

Data Converters Amplifiers

Special Linear Products Support Components

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REFERRENCEMANL
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DATA CONVERTERS
AMPLIFIERS
SPECIAL LINEAR PRODUCTS
SUPPORT COMPONENTS

## How to Find Product Data in This Reference Manual

## THIS VOLUME^

Contains Data Sheets, Selection Guides and a wealth of background information on state-of-the-art products that are suitable for new equipment design.
This volume is one member of a six-volume set of reference manuals describing and specifying Special Linear, Amplifier, Converter and Military/Aerospace products from Analog Devices, Inc.

## IF YOU KNOW THE MODEL NUMBER

Turn to the product index at the back of the book and look up the model number. You will find the Section-Page location of any data sheet in this volume. You will find additional references for all other Analog Devices products currently available.
If you're looking for a form-and-function-compatible version of a product originally brought to market by some other manufacturer (second source), you may find it by adding our "AD" prefix and looking it up in the index. Or call our nearest sales office.

## IF YOU DON'T KNOW THE MODEL NUMBER

Find your functional group in the list on the opposite page. Turn directly to the appropriate Section. You will find a functional Selection Tree and Selection Guide at the beginning of the Section. The Selection Tree and Selection Guide will help you find the products that are the closest to satisfying your need. Use them to compare all products in the category by salient criteria. A comprehensive Table of Contents is provided for your convenience on page 1-5 through 1-15.

## IF YOU CAN'T FIND IT HERE . . . ASK

If you can't find the product you are looking for in this databook, please contact your local Analog Devices sales officer or phone our Applications Department at 617-937-1428 or 1-800-262-5643 (U.S.A. only).
See the Worldwide Sales Directory on pages 24-16 and 24-17 at the back of this volume for our sales office phone numbers.
*The fax retrieval system number shown on abridged and preliminary data sheets applies to U.S.A. and Canada only.

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## 1994 <br> DESIGN-IN REFERENCE MANUAL

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## USE IN LIFE SUPPORT APPLICATIONS

Products sold by Analog Devices are not designed for use in life support equipment where malfunction of such products ca reasonably be expected to result in personal injury or death. Buyer uses or sells such products for life support application at buyer's own risk and agrees to defend, indemnify, and hold harmless Analog Devices from any and all damages, claims, suits, or expense resulting from such use.

## General Information Contents

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Analog Devices, a Fortune 500 Industrials company, designs, manufactures and sells worldwide sophisticated electronic components and subsystems for use in real-world signal processing. More than six hundred standard products are produced in manufacturing facilities located throughout the world. These facilities encompass all relevant technologies, including several embodiments of CMOS, BiMOS, bipolar and hybrid integrated circuits, each optimized for specific attributes-and assembled products in the form of potted modules, printed-circuit boards and instrument packages.
State-of-the-art technologies (including surface micromachining) have been utilized (and in many cases invented) to provide timely, reliable, easy-to-use advanced designs at realistic prices. Our popular IC products are available in both conventional and surface-mount packages (SOIC, LCC, PLCC), and many of our assembled products employ surface-mount technology to reduce manufacturing costs and overall size. A quarter-century of successful applications experience and continuing vertical integration ensure that these products are oriented to user needs. The ongoing application of today's state-of-the-art and the invention of tomorrow's state-of-the-art processes strengthen the leadership position of Analog Devices in standard data-acquisition and signal-processing products and make us a strong contender in high performance mixed-signal ASICs.

## MAJOR PROGRESS

Since publication of the selection guides in the current set of Reference Manuals, Analog Devices has introduced more than 200 significant new products; they run the gamut from brand new product and market categories and technologies to standard products (with improvements in price, performance, or design) to augmented second source products. All of the newest products in the area of standard data converter, amplifier, and special purpose linear are included in this volume, with our latest offerings in DSP and special function products for audio, communications, and computer peripherals to be published in our forthcoming DSP Reference Manual.
Examples of the variety, performance, and innovation content of outstanding new linear and data converter products to be found in this volume include:

- AD8001/AD8002 800 MHz single and dual current feedback operational amplifiers that use only 50 mW from $\pm 5$ volt sup-plies-first amplifiers from the XFCB process
- ADXL05 second generation surface-micromachined accelerometer with $\pm 5 \mathrm{~g}$ full scale and better than 1 milli-g useful resolution
- AD7716 22-bit quad-input sigma-delta ADC with 105 dB dynamic range at 146 Hz bandwidth on 50 mW from $\pm 5$ volt supplies
- AD420 16-bit complete digital-to-4-20 mA current loop driver with serial interface and 3 MHz update rate
- AD720/AD721 RGB to NTSC/PAL encoders needing no external filters or delay lines
- AD878 14-bit 2.2 Msps ADC complete with SHA and reference using only 500 mW
- AD607 complete receiver IF subsystem with mixer/AGC/ RSSI from 3 volt supply
- AD9101 125 MHz sample-hold amplifier with 350 MHz signal bandwidth
- OP291/OP491 rail-to-rail input/output dual and quad op amps that work down to a 2.7 volt single supply
- AD7853/AD7858 single/octal input 12 -bit 200 Msps sampling ADCs using only 5.5 mW from a 3 volt supply
- REF190 Series precision references with 0.5 volt dropout voltage, $\pm 2 \mathrm{mV}$ accuracy, and $45 \mu \mathrm{~A}$ supply current.
Many more could be added to this list.


## DESIGN-IN REFERENCE MANUAL

This volume provides comprehensive technical data on the latest Analog Devices standard linear and data conversion products for all of the electronic industries we serve, with particular focus on the industrial, instrumentation, and military markets. This Design-In Reference Manual contains technical information on all of the standard linear products that we recommend for new designs. This is a companion volume and update to the series of Reference Manuals we began publishing in 1992. These manuals include the two-volume Data Converter Reference Manual, Amplifier Reference Manual, Special Linear Reference Manual, and the Applications Reference Manual. While this volume provides up-to-date information on our products, products which have appeared in a Reference Manual previously may have an abbreviated data sheet, so it is important to retain the entire set of Reference Manuals to have complete applications information about all of our products. If you need one of the previously printed Manuals, you can order it from our Literature Center.
In the approximately 2400 pages of this volume you will find:

- Recently released products with a complete data sheet containing all application and packaging information required to design in the product.
- Design-in products appearing in a previous Reference Manual which may have an abbreviated data sheet containing only specifications, packaging, pinout, and block diagram information, sufficient to make a design choice, but possibly not sufficient to complete a design; the full data sheets on these products are in the previously printed Reference Manuals.
- Advance technical information on upcoming new products which may prompt you to seek more up-to-date information on the product.
- Selection guides and product function trees for finding products rapidly.
- A representative list of available Analog Devices technical publications on real-world analog and digital signal processing.
- Our Worldwide Sales Directory.
- The complete Product Index to all Analog Devices products currently available or soon to be released which are covered in any of our Reference Manuals or the upcoming DSP Reference Manual.

The product data in this book are intended primarily for the majority of users who are concerned with new designs. For this reason, existing and available products that offer little if any unique advantage over newer products in future designs are listed in the Index, and data sheets may be available sepa-rately-but they are not published in this book.

## TECHNICAL SUPPORT

Our extensive technical literature discusses the technology and applications of products for real-world signal processing. Besides tutorial material and comprehensive data sheets, including a large number in our reference manuals, we offer application notes, application guides, technical handbooks (at reasonable prices), and several free serial publications. For example, Analog Briefings ${ }^{\circledR}$ provides current information about products for military/avionics, and Analog Dialogue, our technical magazine, provides in-depth discussions of new developments in analog and digital circuit technology as applied to data acquisition, signal processing, control, and test. DSPatch ${ }^{\circledR}$ is a quarterly newsletter that brings its readers up-to-date applications information on our DSP products and the general field of digital signal processing. We maintain a mailing list of engineers, scientists, and technicians with a serious interest in our products. In addition to these reference manual catalogs-and general short-form selection guides-we also publish several short-form catalogs on specific product families. You will find typical publications described on pages 24-11 to 24-15 at the back of the book.

## SALES AND SERVICE

Backing up our design and manufacturing capabilities and our extensive array of publications, is a network of distributors, plus sales offices and representatives throughout the United States and most of the world, staffed by experienced sales and applications engineers. Our Worldwide Sales Directory, as of the publication date, appears on pages 24-16 and 24-17 at the back of the book.

## RELIABILITY

The manufacture of reliable products is a key objective at Analog Devices. The primary focus is a companywide Total Quality Management (TQM) Program. In addition, we maintain facilities that have been qualified under such standards as MIL-M-38510 (Class B and Class S) for ICs in the U.S., MIL-STD-1772 for hybrids, and ISO9000 (required by many European customers). Many of our products-both proprietary and second-source-have qualified for JAN part numbers; others are in the process. A larger number of products-including many of the newer ones just starting the JAN qualification prócess-are specifically characterized on Standard Military Drawings (SMDs). Most of our ICs are available in versions that comply with MIL-STD-883C Class B, and many also comply with Class S. We publish a Military/Aerospace Reference Manual for
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designers who specify ICs and hybrids for military contracts. The 1994 issue contains data on 379 product families. It also contains Mil/Aero Product Cross Reference Guides, radiation information and space qualified products information. Our newsletter Analog Briefings provides current information about the status of reliability at ADI.
Our PLUS program makes available standard devices (commercial and industrial grades, plastic or ceramic packaging) for any user with demanding application environments, at a small premium. Subjected to stringent screening, similar to MIL-STD883 test methods, these devices are suffixed "/+" and are available from stock.

## PRODUCTS NOT FOUND IN THE SELECTION GUIDES

For maximum usefulness to designers of new equipment, we have limited the contents of selection guides to standard products most likely to be used for the design of new circuits and systems with the exception of digital signal processing products. For DSP products to be included in our forthcoming Digital Signal Processing Reference Manual, please turn to page 24-6 at the back of this volume, Otherwise, if the model number of a product you are interested in is not in the Table of Contents, turn to page 24-4 where you will find a list of older products for which data sheets are available upon request. On page 24-7 you will find a guide to substitutions (where possible) for products no longer available.
ICs embodying combinations of functions that you need but cannot find among our standard offerings may be available to meet your specific requirements as custom designs. For more information, get in touch with Analog Devices. A complete Worldwide Sales Directory is included on pages 24-16 and 24-17.

## PRICES

Accurate, up-to-date prices are an important consideration in making a choice among the many available product families. Since prices are subject to change, current price lists and/or quotations are available upon request from our sales offices and distributors.

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AD7874 - LC ${ }^{2}$ MOS 4-Channel, 12-Bit Simultaneous Sampling Data Acquisition System ..... 2-329
AD7878- LC ${ }^{2}$ MOS Complete 12-Bit 100 kHz Sampling ADC with DSP Interface ..... 2-333
AD7880 - LC ${ }^{2}$ MOS Single +5 V Supply, Low Power, 12-Bit Sampling ADC ..... 2-337
AD7882- LC ${ }^{2}$ MOS 16 -Bit $2.5 \mu \mathrm{~s}$, Sampling ADC ..... 2-341
AD7883 - LC² MOS 12-Bit, 3.3 V Sampling ADC ..... 2-353
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AD7892 - LC ${ }^{2}$ MOS Single Supply, 12-Bit 600 kSPS ADC ..... 2-375
AD7893 - LC ${ }^{2}$ MOS 12-Bit, Serial 6 us ADC in 8-Pin Package ..... 2-383
AD7896-3 V, LC ${ }^{2}$ MOS 12-Bit, Serial 8 us ADC in 8-Pin Package ..... 2-393
AD9000 - High Speed 6-Bit A/D Converter ..... 2-399
AD9002 - High Speed 8-Bit Monolithic A/D Converter ..... 2-402
AD9012 - High Speed 8-Bit TTL A/D Converter ..... 2-406
AD9020 - 10-Bit 60 MSPS A/D Converter ..... 2-410
AD9022-12-Bit 20 MSPS Monolithic A/D Converter ..... 2-414
AD9023-12-Bit 20 MSPS Monolithic A/D Converter ..... 2-422
AD9027 - 12-Bit, 31 MSPS Monolithic A/D Converter ..... 2-429
AD9032 - 12-Bit 25 MSPS A/D Converter ..... 2-437
AD9040A - 10-Bit 40 MSPS A/D Converter ..... 2-444
AD9048 - Monolithic 8-Bit Video A/D Converter ..... 2-455
AD9050 - 10-Bit 40 MSPS ADC ..... 2-458
AD9058 - Dual 8-Bit 50 MSPS A/D Converter ..... 2-461
AD9060 - 10-Bit 75 MSPS A/D Converter ..... 2-465

## Selection Trees - Analog-to-Digital Converters



* DAS = Data Acquisition System: MUX, T/H \& A/D


## Selection Trees - Analog-to-Digital Converters




## Selection Trees - Analog-to-Digital Converters


${ }^{1}$ Subranging or $1 / 2$ Flash
${ }^{2}$ Contact Factory For Versions Up to 2 MHz


## Selection Trees - Analog-to-Digital Converters




## Selection Guides-Analog-to-Digital Converters

## Sampling ADCs

| Model | Res Bits | Throughput Rate kSPS max | SHA <br> BW <br> kHz <br> $\operatorname{typ}^{1}$ | Reference <br> Volt <br> Int/Ext ${ }^{2}$ | Bus Interface Bits ${ }^{3}$ | Package Options ${ }^{4}$ | Temp Ranges ${ }^{5}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| AD7821 | 8 | 1000 | 100 | 0-5 V, Ext | 8, $\mu \mathrm{P}$ | $\mathbf{E}, \mathbf{N}, \mathbf{P}, \mathbf{Q}, \mathbf{R}$ | I, M/ ${ }_{\text {D }}$ |
| AD8401 | 8 | 500 | 200 | Int | 8, $\mu \mathrm{P}$ | R | I |
| AD7820 | 8 | 500 | 14 | 0-5 V, Ext | $8, \mu \mathrm{P}$ | E, N, P, Q, R | I, M/D |
| AD7569 | 8 | 400 | 200 | Int | 8, $\mu \mathrm{P}$ | $\mathbf{E}, \mathbf{N}, \mathbf{P}, \mathbf{Q}, \mathbf{R}$ | C, I, M/D |
| AD7669 | 8 | 400 | 200 | Int | 8, $\mu \mathrm{P}$ | $\mathbf{N}, \mathbf{P}, \mathbf{R}$ | C, I, M |
| AD7769 | 8 | 400 | 200 | Ext | 8, $\mu \mathrm{P}$ | N, P | C, I |
| AD7824 | 8 | 400 | 10 | 0-5 V, Ext | 8, $\mu \mathrm{P}$ | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, $\mathbf{I}, \mathrm{M} / \mathrm{D}$ |
| AD7828 | 8 | 400 | 10 | 0-5 V, Ext | 8, $\mu \mathrm{P}$ | $\mathbf{E}, \mathbf{N}, \mathbf{P}, \mathbf{Q}$ | C, I, M/D |
| AD7575 | 8 | 190 | 50 | 1.23 V , Ext | 8, $\mu \mathrm{P}$ | $\mathbf{E}, \mathbf{N}, \mathbf{P}, \mathbf{Q}$ | C, $\mathbf{I}, \mathrm{M} / \mathrm{D}$ |
| AD7776 | 10 | 400 | 1000 | 2.0 V, Int/Ext | 10, $\mu \mathrm{P}$ | N, R | C, I |
| AD7777 | 10 | 400 | 1000 | 2.0 V, Int/Ext | 10, $\mu \mathrm{P}$ | N, R | C, I |
| AD7778 | 10 | 400 | 1000 | 2.0 V, Int/Ext | 10, $\mu \mathrm{P}$ | S | C, I |
| AD872 | 12 | 10,000 | 70,000 | +2.5 V/Int | 12 | D, E | C, $\mathrm{M}_{\mathrm{D}}$ |
| AD1671 | 12 | 1250 | 2000 | 2.5 V, Int | 12 | Q, P | C, I, M ${ }_{\text {D }}$ |
| AD7886 | 12 | 750 | 1000 | 5 V , Ext | 12, $\mu \mathrm{P}$ | $\mathbf{N}, \mathbf{P}, \mathbf{Q}$ | C, I |
| AD7891 | 12 | 600 | 1200 | 2.5, Int | 8/12, Serial, $\mu \mathrm{P}$ | P, S | I, M |
| AD7892 | 12 | 600 | 600 | 2.5, Int | 12, Serial, $\mu \mathrm{P}$ | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M |
| AD678 | 12 | 200 | 1000 | 5 V , Int | 8/12, $\mu \mathrm{P}$ | D, J, N | C, I, M |
| AD7853 | 12 | 200 | 1000 | Int | Serial, $\mu \mathrm{P}$ | N, R, RS | I |
| AD7858 | 12 | 200 | 1000 | Int | Serial, $\mu \mathbf{P}$ | N, R, RS | I |
| AD1341 | 12 | 150 | 2500 | 10 V , Int | 16, $\mu \mathrm{P}$ | Z | C, M/ |
| AD7893 | 12 | 140 | 1000 | 2.5 V, Ext | Serial | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M |
| AD7896 | 12 | 125 | 300 | Int | Serial | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M |
| AD7874 | 12 | 116 | 500 | Int (+3 V), Ext | 12, $\mu \mathrm{P}$ | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M/D |
| AD7870 | 12 | 100 | 500 | 3 V , Int | 8/12/Serial, $\mu \mathrm{P}$ | $\mathbf{N}, \mathbf{P}, \mathbf{Q}$ | C, $\mathrm{I}, \mathrm{M} /{ }_{\mathrm{D}}$ |
| AD7870A | 12 | 100 | 500 | 3 V , Int | 8/12/Serial, $\mu \mathrm{P}$ | N, P, Q | C, I, M/D |
| AD7875 | 12 | 100 | 500 | 3 V , Int | 8/12/Serial, $\mu \mathrm{P}$ | $\mathbf{N}, \mathbf{P}, \mathbf{Q}$ | C, I, M/D |
| AD7876 | 12 | 100 | 500 | 3 V , Int | 8/12/Serial, $\mu P$ | $\mathbf{N}, \mathbf{P}, \mathbf{Q}$ | I, M |
| AD7878 | 12 | 100 | 500 | 3 V , Int | 12, $\mu \mathrm{P}$ | $\mathbf{E}, \mathbf{N}, \mathbf{P}, \mathbf{Q}$ | C, $\mathrm{I}, \mathrm{M} / \mathrm{D}$ |


| Comments | Page ${ }^{6}$ |
| :---: | :---: |
| CMOS, Bipolar or Unipolar Operation | 2-295 |
| 4-Channel, 5 V , with 8-Bit DAC | 5-102 |
| CMOS, 8-Bit Sampling ADC | CII 2-51 |
| CMOS, Complete I/O Port with DAC, ADC, | 2-19 |
| CMOS, Complete I/O Port with 2 DACs, | 2-196 |
| ADC, SHA, Amps and Reference |  |
| CMOS, Complete 2-Channel I/O Port with | CII 8 |
| Input/Output Signal Conditioning |  |
| CMOS, 4-Channel, 8-Bit Sampling ADC | 5-64 |
| CMOS, 8-Channel, 8-Bit Sampling ADC | 5-64 |
| CMOS, Low Cost | 2-202 |
| CMOS, Single Channel Complete Sampling ADC, | 5-54 |
| Single Supply, Twos Complement Output Code |  |
| CMOS, 4-Channel Complete ADC for Single or | 5-54 |
| Simultaneous Dual Channel Sampling, Single Supply |  |
| CMOS, 8 -Channel Complete ADC for Single or | 5-54 |
| Simultaneous Dual Channel Sampling, Single Supply |  |
| Complete, Monolithic 12-Bit, 10 MSPS ADC | 2-137 |
| Complete, Monolithic 12-Bit, 1.25 MSPS ADC | 2-177 |
| CMOS, 12-Bit 750 kSPS Sampling ADC | 2-369 |
| 8 -Channel High Speed, 5 V Supply | 5-92 |
| 5 Volt Supply, Variable Range, Protected | 2-375 |
| BiMOS, High Impedance High Bandwidth | 2-71 |
| Sampling Input, 10 V Range, AC/DC Tested |  |
| 3 V Supply, Self-Calibrating, Low Power | 2-299 |
| 3 V Supply, 8 Channel, Self-Calibrating | 2-299 |
| High Speed 8/16 Channel DAS | CII 7-25 |
| CMOS, Single Supply Sampling ADC in 8 -Pin Package | 2-383 |
| 3 Volt Serial ADC in 8 -Pin Package | 2-393 |
| CMOS, Simultaneous Sampling 4-Channel ADC | 2-329 |
| for $\pm 10 \mathrm{~V}$ Input Signals |  |
| CMOS, 100 kHz Throughput, $\pm 3 \mathrm{~V}$ Input | 2-317 |
| CMOS, 100 kHz Throughput, $\pm 3 \mathrm{~V}$ Input | 2-317 |
| CMOS, 100 kHz Throughput, 0-5 V Input | 2-317 |
| CMOS, 100 kHz Throughput, $\pm 10 \mathrm{~V}$ Input | 2-317 |
| CMOS, 100 kHz Throughput, $\pm 3 \mathrm{~V}$ Input, On-Chip FIFO | 2-333 |



## Selection Guides-Analog-to-Digital Converters

## Nonsampling ADCs

| Model | Res Bits | Conv <br> Rate <br> $\mu \mathrm{s}$ <br> max | Reference <br> Voltage <br> Int/Ext ${ }^{1}$ | Bus <br> Interface <br> Bits ${ }^{2}$ | Package Options ${ }^{3}$ | Temp Ranges ${ }^{4}$ | Comments | Page ${ }^{5}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ADC-908 | 8 | 6.0 | -10 V , Ext | 8, $\mu \mathrm{P}$ | N, Q, E, R | C, I, M/ ${ }_{\text {D }}$ | CMOS, +5 V Operation, Fast | D |
| AD670 | 8 | 10 | Int | 8, $\mu \mathrm{P}$ | D, N, E, P | C, I, M/ ${ }_{\text {D }}$ | Single +5 V Supply, Including In-Amp and Reference | 2-28 |
| AD7576 | 8 | 10 | 1.23 V, Ext | $8, \mu \mathrm{P}$ | N, Q, E, P | C, I, M/ | CMOS, Low Cost, Single Supply | CII 2-509 |
| AD7574 | 8 | 15 | -10 V, Ext | 8, $\mu \mathrm{P}$ | N, Q | C, I, M/D | CMOS, +5 V Operation | CII 8-63 |
| AD570 | 8 | 25 | Int | 8 | D | C, $\mathrm{M} / \mathrm{D}$ |  | 2-17 |
| AD673 | 8 | 30 | Int | 8, $\mu \mathrm{P}$ | D, N, P | C, $\mathbf{M} / \mathbf{D}$ |  | 2-37 |
| AD7581 | 8 | 66.7 | -5 V to ( -15 V ), Ext | 8, $\mu \mathrm{P}$ | N, Q, P | C, I | CMOS 8-Bit ADC | CII 2-363 |
| AD579 | 10 | 1.8 | 10 V , Int | 10/Serial | D | SM/ | High Speed with Low Power | CII 2-61 |
| AD875 | 10 | 0.067 | 2.4 V, +4 V, Ext | 10 | S | C | CMOS, $165 \mathrm{~mW}, 10-\mathrm{Bit}$, 15 MHz ADC | 2-156 |
| ADC-910 | 10 | 6.0 | 2.5 V , Int | 8, 10, $\mu \mathrm{P}$ | Q | C, I, M/ | Bipolar, Fast with Byte Output | CII 2-819 |
| AD571 | 10 | 25 | Int | 10 | D | C, $\mathrm{M} / \mathrm{D}^{\text {d }}$ | Complete 10-Bit ADC | 2-17 |
| AD573 | 10 | 30 | Int | 8/10, $\mu \mathrm{P}$ | D, N, P | C, $\mathrm{M} / \mathrm{D}$ | Complete 10-Bit ADC, Byte or Parallel Interface | 2-21 |
| AD671 | 12 | 0.5 | 5 V , Ext | 12 | D | C, M/ | 12-Bit 500 ns Monolithic ADC | 2-32 |
| AD7586 | 12 | 1 | -4 V, Ext | 12, $\mu \mathrm{P}$ | N, Q, P | C, I, M | CMOS 12-Bit, 1 MHz ADC | CII 2-383 |
| AD578 | 12 | 3 | 10 V , Int | 12 | D | C, M/ ${ }_{\mathrm{D}}$ | Complete, $3 \mu \mathrm{~s}, 12$-Bit ADC | CII 2-61 |
| AD7572A | 12 | 3 | Int | 8/12, $\mu \mathrm{P}$ | N, Q, R | C, I | Improved Version of Industry Standard | CII 2-303 |
| AD7572 | 12 | 5 | Int | 8/12, $\mu \mathrm{P}$ | N, Q, E, P | C, I, M/ ${ }_{\text {D }}$ | Industry Standard, 12-Bit ADC | CII 2-299 |
| ADC-170 | 12 | 5.6 | -5.25 V, Ext | Serial | N, Q, R | $\mathrm{I}, \mathrm{M}$ | Complete, $3 \mu \mathrm{~s}, 12$-Bit ADC in 8 -Pin Mini-DIP | CII 2-817 |
| AD774B | 12 | 8 | 10 V , Int | 8/12, $\mu \mathrm{P}$ | D, N, R | C, I, M/ | Faster Version of AD674B, Industry Standard | CII 2-109 |
| AD ADC84 | 12 | 10 | 6.3 V, Int | 12 | D | C, I, M | Industry Standard | CII 2-809 |
| AD ADC85 | 12 | 10 | 6.3 V, Int | 12 | D | C, I, M/ | Industry Standard | CII 2-809 |
| ADC-912A | 12 | 10 | -5 V, Ext | 12, $\mu \mathrm{P}$ | N, Q, R | I, M/ | CMOS, Improved Version of ADC-912 | CII 2-831 |
| AD5210 | 12 | 13 | $-10 \mathrm{~V}, \mathrm{Int} / \mathrm{Ext}$ | 12 | D | I, M/ | Industry Standard (AD5211/12/14/15) | D |
| AD674B | 12 | 15 | 10 V, Int | 8/12, $\mu \mathrm{P}$ | D, N, R | C, I, M/D | Improved Version of AD674A/AD574A, Industry Standard | 2-39 |
| AD572 | 12 | 25 | 10 V , Int | 12 | D | I, M/ | 12-Bit Successive Approximation ADC | CII 2-31 |
| AD ADC80 | 12 | 30 | 6.3 V, Int | 12 | D | I | Industry Standard | CII 2-803 |
| AD574A | 12 | 35 | 10 V , Int | 8/12, $\mu \mathrm{P}$ | D, N, E, P | C, M/ ${ }_{\text {DJ }}$ | Complete ADC with Reference and Clock; Industry Standard | 2-24 |
| AD5200 | 12 | 50 | -10 V, Int/Ext | 12 | D | I, M/ | Industry Standard (AD5201/02/04/05) | D |
| AD7578 | 12 | 100 | 5 V , Ext | 8, $\mu \mathrm{P}$ | D, N, Q | C, I, M/ | CMOS, 1 LSB Total Unadjusted Error | CII 2-335 |


 reference is pinned out.
${ }^{2}$ This column lists the data format for the bus with " $\mu \mathrm{P}$ " indicating microprocessor capability-i.e., for a 13 -bit converter $8 / 12$, $\mu \mathrm{P}$ indicates that the data can be formatted for an 8 -bit bus or can be in parallel ( 12 bits) and is microprocessor compatible.

 Glass DIP; $14=\mathrm{J}$-Leaded Ceramic Package; $15=$ Ceramic Pin Grid Array; $16=$ TO-92.
Temperature Ranges: $\mathrm{C}=$ Commercial, 0 to $+70^{\circ} \mathrm{C} ; \mathrm{I}=$ Industrial, $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ (Some older products $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ); $\mathrm{M}=$ Military, $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
${ }^{\circ} \mathrm{CII}=$ Data Converter Reference Manual, Volume II; D = Data Sheet. All other entries pertain to this volume
Boldface Type: Datasheet information in this volume.

## Selection Guides - Analog-to-Digital Converters

High Speed ADCs

| Model | Res Bits | Throughput Rate MSPS min | Full Power BW MHz typ | Bus <br> Interface <br> Bits ${ }^{1}$ | Reference <br> Voltage <br> Int/Ext ${ }^{2}$ | Package Options ${ }^{3}$ | Temp Range ${ }^{4}$ | Page ${ }^{5}$ | Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| AD9000 | 6 | 77 | 20 | 6 | 0.5-2 V, Ext | D, $\mathbf{Q}$ | C, M/ | 2-399 | MIL-STD-883, Rev. C, Devices Available; Low Error Rate |
| AD9002 | 8 | 150 | 160 | 8 | 0.1-(-2.1) Ext | $\mathbf{D}, \mathbf{E}, \mathbf{J}$ | I, $\mathbf{M} / \mathbf{D}$ | 2-402 | Single Supply, Low Power, Low Input Capacitance, MIL-STD-883, Rev. C Device Available |
| AD9012 | 8 | 100 | 160 | 8 | -2 V, Ext | E, J, Q | I, M/D | 2-406 | TTL Outputs, Low Power, Low Input Cap |
| AD9058 | 8 | 50 | 175 | 8 | +2 V, Int | D, J | C, M/ | 2-461 | Dual 8-Bit, TTL Output |
| AD9048 | 8 | 35 | 15 | 8 | $-2 \mathrm{~V}, \mathrm{Ext}$ | E, J, Q | C, M/D | 2-455 | 35 MSPS, 8-Bit Video ADC, 16 pF Input Capacitance |
| AD775 | 8 | 20 | - | 8 | 2.8, 0.6 V, Ext | $\mathbf{N}, \mathbf{R}$ | C | 2-95 | Single Supply, Low Power, Low Input Cap |
| AD9060 | 10 | 75 | 175 | 10 | $\pm 1.75 \mathrm{~V}, \mathrm{Ext}$ | E, $\mathbf{Z}$ | C, M/ | 2-465 | Fastest 10-Bit ECL Monolithic ADC |
| AD9020 | 10 | 60 | 175 | 10 | $\pm 1.75 \mathrm{~V}$, Ext | E, Z | C, M/ | 2-410 | Fastest 10-Bit TTL Monolithic ADC |
| AD9040A | 10 | 40 | 48 | 10 | +2.5 V, Int | N, R | C | 2-444 | SNR = 53 dB with 10.3 MHz Input @ 40 MSPS |
| AD9050 | 10 | 40 | 40 | 10 | 2.5 V, Int | R | C | 2-458 | Single Supply, Wide Range, Low Power |
| AD873 | 10 | 30 | 200 | 10 | 3.0, 1.5 V, Ext | $\mathbf{N}, \mathbf{R}$ | C | 2-152 | Single Supply, CMOS, Low Noise |
| AD876 | 10 | 20 | 250 | 10 | 4.0, 2.0 V, Ext | R, ST | C | 2-169 | Single Supply, $140 \mathrm{~mW}, 3.3$ V Interface |
| AD773A | 10 | 20 | 100 | 10 | +2.5, Ext | D | C | 2-81 | Low Power, 10-Bit 20 MSPS with On-Chip T/H |
| AD875 | 10 | 15 | - | 10 | +2 V, +4 V/Ext | S | C | 2-156 | CMOS, $165 \mathrm{~mW}, 10-\mathrm{Bit}$, 15 MHz ADC |
| AD9027 | 12 | 31 | 200 | 12 | Int | D | I | 2-429 | Direct IF to Digital, Wideband, ECL |
| AD9032 | 12 | 25 | 220 | 12 | Int | D, $\mathbf{Z}$ | I, M | 2-437 | World's Fastest Complete 12-Bit ADC |
| AD9034 | 12 | 20 | 150 | 12 | Int | $\mathrm{D}, \mathrm{Z}$ | I, M | D | 20 MSPS |
| AD9023 | 12 | 20 | 115 | 12 | Int | Q, Z | I, M | 2-422 | ECL Compatible Logic, with THA and Reference |
| AD9022 | 12 | 20 | 115 | 12 | Int | Q, $\mathbf{Z}$ | I, M | 2-414 | TTL Compatible Logic, with THA and Reference |
| AD872 | 12 | 10 | 70 | 12 | +2.5 V/Int | D, E | C, $\mathbf{M} /{ }_{\text {D }}$ | 2-137 | Complete, Monolithic 12-Bit 10 MSPS |
| AD9005A | 12 | 10 | 38 | 12 | Int | M | C, M/ | CII 2-697 | Complete 12-Bit ADC with T/H, Reference and Timing Circuitry |
| AD9007 | 12 | 10 | 38 | 12 | Int | M | C | D | $\pm 5$ V Only Version of AD9005A |
| AD871 | 12 | 5 | 15 | 12 | 2.5, Int | D, E | C, $\mathbf{M}$ | 2-121 | Low Noise, High Accuracy, Wide Dynamic Range |
| AD1671 | 12 | 1.25 | 2 | 12 | 2.5 V, Int | $\mathbf{P}, \mathbf{Q}$ | C, I, M/D | 2-177 | Complete, Monolithic 12-Bit, 1.25 MSPS ADC |
| AD9014 | 14 | 10 | 60 | 14 | Int | Board | C | CII 2-729 | Wide Spurious Free Dynamic Range |
| AD878 | 14 | 2.2 | 2 | 14 | 2.5, Int | P | C, I | 2-173 | Low Power, Wide Dynamic Range, Low Cost |
| ${ }^{1}$ This column lists the data format for the bus with " $\mu \mathrm{P}$ " indicating microprocessor capability-i.e., for a 12 -bit converter $8 / 12$, $\mu \mathrm{P}$ indicates that the data can be formatted for an 8 -bit bus or can be in parallel ( 12 bits) and is microprocessor compatible. |  |  |  |  |  |  |  |  |  |
| ${ }^{3}$ Package Op M = Herme Quad Flatpa ${ }^{4}$ Temperature temperature | ns: D <br> Meta <br> ; ST <br> Ranges <br> esignat | Hermetic DIP Can DIP; N = Thin Quad Flat $=$ Commercia will be followe | eramic or Meta stic or Epoxy ck; $\mathrm{T}=\mathrm{TO}-92$ $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$; by: / to indicate | $\mathrm{E}=$ Ceramic <br> ed DIP; $\mathrm{P}=$ <br> $\mathrm{U}=\mathrm{TSOP}$ <br> Industrial, <br> 33B, for JA | eadless Chip Carrier; Plastic Leaded Chip C in Small Outline Pac $0^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ (Some ${ }_{D}$ for SMD, and ${ }_{s}$ fo | $=$ Ceramic F <br> er; $\mathrm{Q}=\mathrm{Cer}$ <br> ge; $\mathrm{W}=$ Non <br> er products pace level. | pack; $G=\mathrm{C}$ ; $\mathrm{R}=$ Small ermetic Ceram $25^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C}$ | mic Pin Grid <br> utline "SOIC" <br> Glass DIP; Y $M=\text { Military }$ | ray; H = Hermetic Metal Can; J = J-Leaded Ceramic Package; Package; RS = SSOP—Shrink Small Outline Package; S = Plastic Single-In-Line "SIP" Package; Z = Ceramic Leaded Chip Carrier. $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. If a device has military grade offerings, the M |
| ${ }^{5} \mathrm{CII}=$ Data Converter Reference Manual, Volume II; D = Data Sheet. All other entries refer to this volume. |  |  |  |  |  |  |  |  |  |

## Sigma-Delta ADCs

| Model | Res Bits | Input <br> BW <br> kHz | Throughput Rate kHz | Reference Voltage Int/Ext ${ }^{1}$ | Bus <br> Interface <br> Bits ${ }^{2}$ | Package Options ${ }^{3}$ | Temp Ranges ${ }^{4}$ | Page ${ }^{5}$ | Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| AD776 | 16 | 50 | 100 to 400 | 2 V , Int | Serial | D | I | 2-103 | 16-Bit 100 kSPS Oversampling ADC, Single Supply |
| AD1878 | 16 | 24 | 2.5 to 50 | 3 V , Int | Serial | N | C | C II 2-295 | Dual Channel, High Performance Stereo 16-Bit Oversampled ADC |
| AD7701 | 16 | 10 Hz | 4 | 2.5 V, Ext | Serial, $\boldsymbol{\mu} \mathbf{P}$ | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | 2-206 | 16-Bit Sigma-Delta ADC, 0.1-10 Hz Input Bandwidth |
| AD28msp02 | 16 | 4 | 8 | 2.5, Ext | Serial, $\mu \mathrm{P}$ | R, N | C | C I 4-25 | Complete Voice Band Linear Codec with On-Chip Filtering |
| AD28msp01 | 16 | 3.4 | 7.2/8.0/9.6 | 2.5, Int | Serial, $\mu \mathrm{P}$ | R, P, N | C | C I 4-9 | Complete Analog Front End for High Performance, DSP-Based Modems |
| AD1879 | 18 | 24 | 2.5 to 50 | 3 V , Int | Serial | N | C | C II 2-297 | Dual Channel, High Performance Stereo 18 -Bit Oversampled ADC |
| AD7703 | 20 | 10 Hz | 4 | 2.5 V, Ext | Serial, $\mu \mathbf{P}$ | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | 2-212 | 20-Bit Sigma-Delta ADC, 0.1-10 Hz Input Bandwidth |
| AD7710 | 24 | $\begin{aligned} & 2.62 \text { to } \\ & 262 \mathrm{~Hz} \end{aligned}$ | $\begin{aligned} & 0.01 \text { to } \\ & 1.0 \end{aligned}$ | 2.5 V, Int | Serial, $\mu \mathrm{P}$ | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | 2-218 | 24-Bit Sigma-Delta Signal Conditioning ADC with 2 Differential Input Channels |
| AD7714 | 24 | 2.62 to 262 Hz | 0.01 to 1.0 | 2.5 V, Ext | Serial, $\mu \mathrm{P}$ | $\mathbf{N}, \mathbf{Q}, \mathbf{R}, \mathbf{R S}$ | I, M | 2-271 | 3 Volt Supply, PGA, 5 Channels |
| AD7711A | 24 | 2.62 to 262 Hz | 0.01 to 1.0 | 2.5 V, Int | Serial, $\mu \mathrm{P}$ | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | 2-265 | AD7711 Function-24 Bits, No Missing Codes |
| AD7711 | 21 | $\begin{aligned} & 2.62 \text { to } \\ & 262 \mathrm{~Hz} \end{aligned}$ | $\begin{aligned} & 0.01 \text { to } \\ & 1.0 \end{aligned}$ | 2.5 V, Int | Serial, $\mu \mathrm{P}$ | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | 2-244 | Similar to AD7710 but 24-Bit Sigma-Delta ADC with 1 Differential, 1 Single-Ended Input and RTD Current Sources |
| AD7712 | 21 | $\begin{aligned} & 2.62 \text { to } \\ & 262 \mathrm{~Hz} \end{aligned}$ | $\begin{aligned} & 0.01 \text { to } \\ & 1.0 \end{aligned}$ | 2.5 V, Int | Serial, $\boldsymbol{\mu} \mathbf{P}$ | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | 2-218 | 24-Bit ADC with 1 Differential Input Channel and 1 High Voltage Input Channel |
| AD7713 | 21 | $\begin{aligned} & 0.52 \text { to } \\ & 52.4 \mathrm{~Hz} \end{aligned}$ | $\begin{aligned} & 2.0 \text { to } \\ & 200 \mathrm{~Hz} \end{aligned}$ | 2.5 V, Ext | Serial, $\mu \mathrm{P}$ | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | 2-244 | Loop Powered 24-Bit Sigma-Delta Signal Conditioning ADC |
| AD7716 | 22 | $\begin{aligned} & 36.5 \text { to } \\ & 584 \mathrm{~Hz} \end{aligned}$ | 1 (max) | 2.5 V, Ext | Serial | S, P |  | 5-40 | 22-Bit Data Acquisition System with with 4 Independent Channels |
| AD1848 | 16 | 8 to 48 kHz | 8 to 48 kHz | 2.25 V, Int | 8 | P, S | C | D | 16-Bit Parallel SoundPort ${ }^{\oplus}$ Stereo Codec. Stereo ADCs and Stereo DACs, PGA, Attenuator and All Filters |
| AD1849 | 16 | 8 to 48 kHz | 8 to 48 kHz | 2.25 V, Int | Serial | P | C | D | 16-Bit Serial SoundPort ${ }^{\circledR}$ Stereo Codec. Stereo ADCs and Stereo DACs, PGA, Attenuator and All Filters. Operates on +5 V Supplies |
| AD7715 | 16 | 5 to 131 Hz | 20 to 500 Hz | 2.5 V, Ext | Serial, $\mu \mathrm{P}$ | N, R | I | 5-28 | 3 Volt, PGA, Low Power, 3-Wire |
| AD7721 | 12 | 210 | 468 | 2.5 V, Ext | 12/Serial, $\mu$ P | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | 2-287 | 5 Volt Supply, FIR Filter, 16-Bit Resolution |

 reference is pinned out.
${ }^{2}$ This column lists the data format for the bus with " $\mu \mathrm{P}$ " indicating microprocessor capability-i.e., for a 12 -bit converter $8 / 12$, $\mu \mathrm{P}$ indicates that the data can be formatted for an 8 -bit bus or can be in parallel ( 12 bits) and is microprocessor compatible.



 temperature designator will be followed by: / to indicate $883 \mathrm{~B},{ }_{\mathrm{J}}$ for JAN, ${ }_{\mathrm{D}}$ for SMD, and ${ }_{\mathrm{S}}$ for space level.
${ }^{5} \mathrm{CI}=$ Data Converter Reference Manual, Volume I; CII = Data Converter Reference Manual, Volume II; D $=$ Data Sheet. All other entries refer to this volume.
Boldface Type: Data sheet information in this volume.
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## Selection Guides-Analog-to-Digital Converters

## Multiplexed ADCs

| Model | Res Bits | \# Chan | Conv Time $\mu \mathrm{s}$ | SHA BW $\mathbf{k H z}$ | Reference <br> Volt <br> Int/Ext ${ }^{1}$ | Bus <br> Interface <br> Bits ${ }^{2}$ | Package Options ${ }^{3}$ | Temp Ranges ${ }^{4}$ | Comments | Page ${ }^{5}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| AD7769 | 8 | 2 | 2.5 | 200 | Ext | 8, $\mu \mathrm{P}$ | N, P | C, I | CMOS, Complete 2-Channel I/O Port with Input/Output Signal Conditioning | CII 8-27 |
| AD7824 | 8 | 4 | 2.5 | 10 | 0-5 V, Ext | 8, $\mu \mathrm{P}$ | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, $\mathrm{I}, \mathrm{M} /{ }_{\mathrm{D}}$ | CMOS, On-Chip Track-Hold | 5-64 |
| AD8401 | 8 | 4 | 2 | 200 | Int | 8, $\mu \mathrm{P}$ | R | I | 5 Volt Supply, DAC Out, High Speed | 5-102 |
| AD7828 | 8 | 8 | 2.5 | 10 | 0-5 V, Ext | 8, $\mu \mathrm{P}$ | $\mathbf{N}, \mathbf{Q}, \mathbf{E}, \mathbf{P}$ | C, I, M/D | CMOS, On-Chip Track-Hold | 5-64 |
| AD7777 | 10 | 4 | 2.5 | 1000 | 2.0 V, Int | 10, $\mu \mathrm{P}$ | N, R | I | Dual SHA, Offset Adjust, CMOS | 5-54 |
| AD7778 | 10 | 8 | 2.5 | 1000 | 2.0 V , Int | 10, $\mu \mathrm{P}$ | S | I | Dual SHA, Offset Adjust, CMOS | 5-54 |
| AD1341 | 12 | 8/16 | 6.67 | 2500 | 10 V , Int | 16, $\mu \mathrm{P}$ | Z | C, M | High Speed, 16-Channel Programmable 12-Bit DAS with 25 ns Bus Interface | CII 7-25 |
| AD7874 | 12 | 4 | $\begin{aligned} & 32.5 \\ & \text { (for } 4 \text { Cha } \end{aligned}$ |  | 3 V Int | 12, $\mu \mathrm{P}$ | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M/ ${ }_{\text {D }}$ | CMOS, Simultaneous Sampling Four-Channel $29 \mathbf{~ k H z ~ A D C ~ f o r ~} \pm 10 \mathrm{~V}$ Input Signals | 2-329 |
| AD363R | 12 | 8/16 | 40 | 2000 | 10 V , Int | 12, $\mu \mathrm{P}$ | D | C, M | High Speed, 16-Channel, 12-Bit DAS | CII 7-5 |
| AD364R | 12 | 8/16 | 50 | 2000 | 10 V , Int | 12, $\mu \mathrm{P}$ | D | C, M | 16-Channel, 12-Bit DAS with Three-State Buffers | CII 7-5 |
| AD7582 | 12 | 4 | 100 | - | 4 V-6 V, Ext | 12, $\mu \mathrm{P}$ | D, N, P, Q | C, I, M/ | CMOS, 1 LSB Total Unadjusted Error | CII 2-371 |
| AD7890 | 12 | 8 | 5 | 1000 | 2.5 V, Ext | Serial, $\mu \mathrm{P}$ | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | CMOS, 8-Channel Multiplexed ADC | 5-76 |
| AD7858 | 12 | 8 | 4.5 | 1000 | Int | Serial, $\mu \mathrm{P}$ | N, R, RS | I | 3 Volt Supply, Low Power, 3-Wire | 2-299 |
| AD7891 | 12 | 8 | 1.6 | 1200 | 2.5 V, Int | 12, Serial, $\mu \mathrm{P}$ | P, S | I | 5 Volt, Input Protected, Range Selectable | 5-92 |
| AD7714 | 24 | 5 | 1-100 ms | - | 2.5 V, Ext | Serial, $\mu \mathrm{P}$ | $\mathbf{N}, \mathbf{Q}, \mathbf{R}, \mathbf{R S}$ | I, M | 3 Volt Supply, PGA, Prog. Filter | 2-271 |

[^0] 8- and 10-Bit Analog-to-Digital Converters

## FEATURES

Complete A/D Converters with Reference and Clock AD570: 8 Bit AD571: 10 Bit<br>Fast Successive Approximation Conversion - 25 $\boldsymbol{\mu}$ s No Missing Codes Over Temperature<br>Digital Multiplexing - 3 State Outputs<br>18-Pin Ceramic DIP<br>Low Cost Monolithic Construction<br>MIL-STD-883 Compliant Versions Available

## PRODUCT DESCRIPTIONS

The AD570/AD571 are successive approximation A/D converters consisting of a DAC, voltage reference, clock, comparator, successive approximation register and output buffers - all fabricated on a single chip. No external components are required to perform full accuracy conversions in $25 \mu \mathrm{~s}$.
The AD570/AD571 incorporate advanced integrated circuit design and processing technologies. They employ $\mathrm{I}^{2} \mathrm{~L}$ (integrated logic) processing in the fabrication of the SAR function. Laser trimming of the high stability SiCr thin-film resistor ladder network insures high accuracy, which is maintained with a temperature compensated, subsurface Zener reference.
Operating on supplies of +5 V to +15 V and -15 V , the AD570/ AD571 will accept analog inputs of 0 to +10 V , unipolar or $\pm 5 \mathrm{~V}$ bipolar, externally selectable. As the BLANK and CON$\overline{\text { VERT }}$ input is driven low, the three-state outputs will be open and a conversion will commence. Upon completion of the conversion, the DATA $\overline{\text { READY }}$ line will go low and the data will appear at the output. Pulling the BLANK and CONVERT high blanks the outputs and readies the device for the next conversion.

The devices are available in two versions: the " J " and " K " specified for the 0 to $+70^{\circ} \mathrm{C}$ temperature range. The " S " guarantees the specified accuracy and no missing codes from $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.

FUNCTIONAL BLOCK DIAGRAM


## PRODUCT HIGHLIGHTS

1. The AD571 is a complete 10 -bit A/D converter. The AD570 is an 8 -bit version which employs the same architecture. No external components are required to perform a conversion.
2. The AD570/AD571 are single chip devices employing advanced IC processing techniques. Thus, the user has at his disposal a truly precision component with the reliability and low cost inherent in monolithic construction.
3. The converters accept either unipolar ( 0 to +10 V ) or bipolar ( -5 V to +5 V ) analog inputs by simply grounding or opening a single pin.
4. Each device offers the specified accuracy with no missing codes over its entire operating temperature range.
5. Operation is guaranteed with -15 V and +5 V to +15 V supplies. The devices will also operate with a -12 V supply.
6. The AD570 and AD571 are available in versions compliant with MIL-STD-883. Refer to the Analog Devices Military Products Databook or current /883B data sheet for detailed specifications.

[^1] sured with respect to digital common, unless otherwise indicated)

| Model | Min | $\begin{gathered} \mathbf{D 5 7 0 J} \\ \mathbf{T y p} \end{gathered}$ | Max | Min | D570S <br> Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| RESOLUTION ${ }^{1}$ |  |  | 8 |  |  | 8 | Bits |
| RELATIVE ACCURACY <br> $T_{\text {min }}$ to $T_{\text {max }}$ |  |  | $\pm 1 / 2$ |  |  | $\pm 1 / 2$ | LSB |
| FULL-SCALE CALIBRATION |  | $\pm 2$ |  |  | $\pm 2$ |  | LSB |
| UNIPOLAR OFFSET |  |  | $\pm 1 / 2$ |  |  | $\pm 1 / 2$ | LSB |
| BIPOLAR ZERO |  |  | $\pm 1 / 2$ |  |  | $\pm 1 / 2$ | LSB |
| DIFFERENTIAL NONLINEARITY $T_{\text {min }} \text { to } T_{\text {max }}$ | 8 |  |  | 8 |  | $\therefore \quad \therefore$ | Bits |
| TEMPERATURE RANGE | 0 |  | +70 | -55 |  | +125 | ${ }^{\circ} \mathrm{C}$ |
| TEMPERATURECOEFFICIENTS <br> Unipolar Offset Bipolar Offset Full-Scale Calibration |  |  | $\begin{aligned} & \pm 1 \\ & \pm 1 \\ & \pm 2 \end{aligned}$ |  |  | $\begin{aligned} & \pm 1 \\ & \pm 1 \\ & \pm 2 \end{aligned}$ | $\begin{aligned} & \text { LSB } \\ & \text { LSB } \\ & \text { LSB } \end{aligned}$ |
| POWER SUPPLY REJECTION <br> CMOS Positive Supply $+13.5 \mathrm{~V} \leq \mathrm{V}+\leq+16.5 \mathrm{~V}$ <br> TTL Positive Supply $+4.5 \mathrm{~V} \leq \mathrm{V}+\leq+5.5 \mathrm{~V}$ <br> Negative Supply $-16.0 \mathrm{~V} \leq \mathrm{V}-\leq-13.5 \mathrm{~V}$ | - - | - | $\pm 2$ $\pm 2$ | - | - | $\begin{aligned} & \pm 2 \\ & \pm 2 \end{aligned}$ | $\begin{aligned} & \text { LSB } \\ & \text { LSB } \\ & \text { LSB } \end{aligned}$ |
| ANALOG INPUT IMPEDANCE | 3.0 | 5.0 | 7.0 | 3.0 | 5.0 | 7.0 | $\mathrm{k} \Omega$ |
| ANALOG INPUT RANGES <br> Unipolar Bipolar | $\begin{aligned} & 0 \\ & -5 \end{aligned}$ |  | $\begin{aligned} & +10 \\ & +5 \end{aligned}$ | $\begin{aligned} & 0 \\ & -5 \end{aligned}$ |  | $\begin{aligned} & +10 \\ & +5 \end{aligned}$ | $\begin{aligned} & \mathbf{V} \\ & \mathbf{v} \end{aligned}$ |
| OUTPUT CODING <br> Unipolar <br> Bipolar | Positive True Binary <br> Positive True Offset Binary |  |  | Positive True Binary <br> Positive True Offset Binary |  |  |  |
| ```LOGICOUTPUT Output Sink Current \(\left(\mathrm{V}_{\text {OUT }}=0.4 \mathrm{~V}\right.\) max, \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) ) Output Source Current \(\left(\mathrm{V}_{\text {OUT }}=2.4 \mathrm{~V}_{\text {max }}, \mathrm{T}_{\text {min }}\right.\) to \(\left.\mathrm{T}_{\text {max }}\right)\) Output Leakage``` | $\begin{aligned} & 3.2 \\ & 0.5 \end{aligned}$ |  | $\pm 40$ | $\begin{aligned} & 3.2 \\ & 0.5 \end{aligned}$ |  | $\pm 40$ | mA <br> mA <br> $\mu \mathrm{A}$ |
| LOGIC INPUTS <br> Input Current <br> Logic "1" <br> Logic "0" | 2.0 |  | $\begin{aligned} & \pm 100 \\ & 0.8 \end{aligned}$ | 2.0 |  | $\begin{aligned} & \pm 100 \\ & 0.8 \end{aligned}$ | $\mu \mathrm{A}$ <br> V <br> V |
| CONVERSION TIME $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ | 15 | 25 | 40 | 15 | 25 | 40 | $\mu \mathrm{s}$ |
| POWER SUPPLY $\begin{aligned} & \text { V + } \\ & \text { V - } \end{aligned}$ | $\begin{aligned} & +4.5 \\ & -12.0 \end{aligned}$ | $\begin{aligned} & +5.0 \\ & -15 \end{aligned}$ | $\begin{aligned} & +7.0 \\ & -16.5 \end{aligned}$ | $\begin{aligned} & +4.5 \\ & -12.0 \end{aligned}$ | $\begin{aligned} & +5.0 \\ & -15 \end{aligned}$ | $\begin{aligned} & +7.0 \\ & -16.5 \end{aligned}$ | $\begin{aligned} & \mathbf{V} \\ & \mathbf{V} \end{aligned}$ |
| OPERATINGCURRENT $\begin{aligned} & \mathbf{V}+ \\ & \mathbf{V}- \end{aligned}$ |  | $\begin{aligned} & 7 \\ & 9 \end{aligned}$ | $\begin{aligned} & 10 \\ & 15 \end{aligned}$ |  |  | $\begin{aligned} & 10 \\ & 15 \\ & \hline \end{aligned}$ | $\mathrm{mA}$ |
| PACKAGEOPTION ${ }^{2,3}$ Ceramic (D-18) | AD570JD |  |  | AD570SD |  |  |  |

## NOTES

${ }^{1}$ The AD570 is a selected version of the AD571 10-bit A-to-D converter. Only TTL logic inputs should be connected to Pins 1 and 18 (or no connection made) or damage may result.
${ }^{2} \mathrm{D}=$ Ceramic DIP. For outline information see Package Information section.
${ }^{3}$ For details on grade and package offerings for SD-grade in accordance with MIL-STD-883, refer to Analog Devices Military
Products databook or current /883B data sheet.
Specifications subject to change without notice.
Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.

| Model | Min | $\begin{aligned} & \text { D571J } \\ & \text { Typp }^{2} \end{aligned}$ | Max | Min | $\begin{aligned} & \text { D571K } \\ & \text { Typ } \end{aligned}$ | Max | Min | AD571S <br> Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| RESOLUTION |  |  | 10 |  |  | 10 |  |  | 10 | Bits |
| RELATIVE ACCURACY, $\mathrm{T}_{\text {A }}$ $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ |  |  | $\begin{aligned} & \pm 1 \\ & \pm 1 \end{aligned}$ |  |  | $\begin{aligned} & \pm 1 / 2 \\ & \pm 1 / 2 \end{aligned}$ |  |  | $\begin{aligned} & \pm 1 \\ & \pm 1 \end{aligned}$ | $\begin{aligned} & \text { LSB } \\ & \text { LSB } \end{aligned}$ |
| FULL-SCALE CALIBRATION |  | $\pm 2$ |  |  | $\pm 2$ |  |  | $\pm 2$ |  | LSB |
| UNIPOLAR OFFSET |  |  | $\pm 1$ |  |  | $\pm 1 / 2$ |  |  | $\pm 1$ | LSB |
| BIPOLAR ZERO |  |  | $\pm 1$ |  |  | $\pm 1 / 2$ |  |  | $\pm 1$ | LSB |
| DIFFERENTIAL NONLINEARITY, $\mathrm{T}_{\mathrm{A}}$ $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ | $\begin{aligned} & 10 \\ & 9 \end{aligned}$ |  |  | $\begin{aligned} & 10 \\ & 10 \end{aligned}$ |  |  | $\begin{aligned} & 10 \\ & 10 \end{aligned}$ |  |  | Bits <br> Bits |
| TEMPERATURERANGE | 0 |  | $+70$ | 0 |  | $+70$ | -55 |  | +125 | ${ }^{\circ} \mathrm{C}$ |
| TEMPERATURECOEFFICIENTS <br> Unipolar Offset <br> Bipolar Offset <br> Full-Scale Calibration |  |  | $\begin{aligned} & \pm 2 \\ & \pm 2 \\ & \pm 4 \end{aligned}$ |  |  | $\begin{aligned} & \pm 1 \\ & \pm 1 \\ & \pm 2 \end{aligned}$ |  |  | $\begin{aligned} & \pm 2 \\ & \pm 2 \\ & \pm 5 \end{aligned}$ | $\begin{aligned} & \text { LSB } \\ & \text { LSB } \\ & \text { LSB } \end{aligned}$ |
| POWER SUPPLY REJECTION <br> CMOS Positive Supply $+13.5 \mathrm{~V} \leq \mathrm{V}+\leq+16.5 \mathrm{~V}$ <br> TTL Positive Supply $+4.5 \mathrm{~V} \leq \mathrm{V}+\leq+5.5 \mathrm{~V}$ <br> Negative Supply $-16.0 \mathrm{~V} \leq \mathrm{V}-\leq-13.5 \mathrm{~V}$ | - | - | $\pm 2$ $\pm 2$ |  |  | $\begin{aligned} & \pm 1 \\ & \pm 1 \\ & \pm 1 \end{aligned}$ | - |  | $\pm 2$ $\pm 2$ | $\begin{aligned} & \text { LSB } \\ & \text { LSB } \\ & \text { LSB } \end{aligned}$ |
| ANALOG INPUT IMPEDANCE | 3.0 | 5.0 | 7.0 | 3.0 | 5.0 | 7.0 | 3.0 | 5.0 | 7.0 | k $\boldsymbol{\Omega}$ |
| ANALOG INPUT RANGES <br> Unipolar Bipolar | $\begin{aligned} & 0 \\ & -5 \end{aligned}$ |  | $\begin{aligned} & +10 \\ & +5 \end{aligned}$ | $\begin{aligned} & 0 \\ & -5 \end{aligned}$ |  | $\begin{aligned} & +10 \\ & +5 \end{aligned}$ | $\begin{aligned} & 0 \\ & -5 \end{aligned}$ |  | $\begin{aligned} & +10 \\ & +5 \end{aligned}$ | $\begin{aligned} & \mathbf{V} \\ & \mathbf{V} \end{aligned}$ |
| OUTPUT CODING <br> Unipolar Bipolar | Positive True Binary <br> Positive True Offset Binary |  |  | Positive True Binary <br> Positive True Offset Binary |  |  | Positive True Binary <br> Positive True Offset Binary |  |  |  |
| ```LOGICOUTPUT Output Sink Current ( \(\mathrm{V}_{\text {OUT }}=0.4 \mathrm{~V}\) max, \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) ) Output Source Current \({ }^{1}\) ( \(\mathrm{V}_{\text {OUT }}=2.4 \mathrm{~V}\) max, \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) ) Output Leakage``` | $\begin{aligned} & \\ & 3.2 \\ & 0.5 \end{aligned}$ |  | $\pm 40$ | $\begin{aligned} & \\ & 3.2 \\ & 0.5 \end{aligned}$ |  | $\pm 40$ | 3.2 0.5 |  | $\pm 40$ | $\begin{gathered} \mathrm{mA} \\ \mathrm{~mA} \\ \mu \mathbf{A} \end{gathered}$ |
| LOGIC INPUTS <br> Input Current <br> Logic "1" <br> Logic "0" | 2.0 |  | $\begin{aligned} & \pm 100 \\ & 0.8 \end{aligned}$ | 2.0 |  | $\begin{aligned} & \pm 100 \\ & 0.8 \end{aligned}$ | 2.0 |  | $\begin{aligned} & \pm 100 \\ & 0.8 \end{aligned}$ | $\begin{aligned} & \mu \mathrm{A} \\ & \mathrm{~V} \\ & \mathrm{~V} \end{aligned}$ |
| CONVERSION TIME <br> $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ | 15 | 25 | 40 | 15 | 25 | 40 | 15 | 25 | 40 | $\mu \mathrm{s}$ |
| POWER SUPPLY <br> V + <br> V - | $\begin{aligned} & +4.5 \\ & -12.0 \\ & \hline \end{aligned}$ | $\begin{aligned} & +5.0 \\ & -15 \\ & \hline \end{aligned}$ | $\begin{aligned} & +7.0 \\ & -16.5 \\ & \hline \end{aligned}$ | $\begin{aligned} & +4.5 \\ & -12.0 \\ & \hline \end{aligned}$ | $\begin{aligned} & +5.0 \\ & -15 \end{aligned}$ | $\begin{aligned} & +16.5 \\ & -16.5 \end{aligned}$ | $\begin{aligned} & +4.5 \\ & -12.0 \\ & \hline \end{aligned}$ | $\begin{aligned} & +5.0 \\ & -15 \\ & \hline \end{aligned}$ | $\begin{aligned} & +7.0 \\ & -16.5 \end{aligned}$ | $\begin{aligned} & \mathbf{V} \\ & \mathbf{V} \end{aligned}$ |
| OPERATINGCURRENT $\begin{aligned} & \mathbf{V}+ \\ & \mathbf{V}- \end{aligned}$ |  | $\begin{aligned} & 7 \\ & 9 \end{aligned}$ | $\begin{aligned} & 10 \\ & 15 \end{aligned}$ |  | $\begin{aligned} & 7 \\ & 9 \end{aligned}$ | $\begin{aligned} & 10 \\ & 15 \end{aligned}$ |  | $\begin{aligned} & 7 \\ & 9 \end{aligned}$ | $\begin{aligned} & 10 \\ & 15 \end{aligned}$ | $\begin{aligned} & \mathrm{mA} \\ & \mathrm{~mA} \\ & \hline \end{aligned}$ |
| PACKAGEOPTION ${ }^{2,3}$ Ceramic (D-18) | AD571JD |  |  | AD571KD |  |  | AD571SD |  |  |  |

NOTES
${ }^{1}$ The data output lines have active pull-ups to source 0.5 mA . The $\overline{\text { DATA READY }}$ line is open collector with
a nominal $6 \mathbf{k} \Omega$ internal pull-up resistor.
${ }^{2}$ D = Ceramic DIP. For outline information see Package Information section.
${ }^{3}$ For details on grade and package offerings for SD-grade in accordance with MIL-STD-883, refer to Analog Devices Military
Products databook or current /883B data sheet.
Specifications subject to change without notice.
Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality
levels. All $\min$ and $\max$ specifications are guaranteed, although only those
shown in boldface are tested on all production units.

## ABSOLUTE MAXIMUM RATINGS



## CHIP BONDING DIAGRAM



## CIRCUIT DESCRIPTION

The AD571 is a complete 10 -bit A/D converter which requires no external components to provide the complete successive approximation analog-to-digital conversion function. The AD570 is an 8 -bit version. A functional block diagram of the AD570/ AD571 is shown below. Upon receipt of the CONVERT command, the internal 10-bit (AD571) current output DAC is sequenced by the $I^{2} L$ successive approximation register (SAR) from its most-significant bit (MSB) to least-significiant bit (LSB) to provide an output current which accurately balances the input signal current through the $5 \mathrm{k} \Omega$ input resistor. The comparator determines whether the addition of each successively weighted bit current causes the DAC current sum to be greater or less than the input current. If the sum is less, the bit is left on; if more, the bit is turned off. After testing all the bits, the SAR contains a 10-bit binary code which accurately represents the input signal to within $\pm 1 / 2 \mathrm{LSB}$ ( $0.05 \%$ ).
Upon completion of the sequences, the SAR sends out a $\overline{\text { DATA }}$ $\overline{\text { READY }}$ signal (active low), which also brings the three-state buffers out of their "open" state, making the bit output lines become active high or low, depending on the code in the SAR. When the BLANK and CONVERT line is brought high, the output buffers again go "open", and the SAR is prepared for another conversion cycle. Details of the timing are given further on.
The temperature compensated buried Zener reference provides the primary voltage reference to the DAC and guarantees excellent stability with both time and temperature. The bipolar offset input controls a switch which allows a positive bipolar offset current to be injected into the summing ( + ) node of the comparator to offset the DAC output. The nominal 0 to +10 V unipolar input range now becomes a -5 V to +5 V range. The $5 \mathrm{k} \Omega$ thinfilm input resistor is trimmed so that with a full-scale input signal, an input current will be generated which exactly matches the DAC output with all bits on. (The input resistor is trimmed slightly low to facilitate user trimming, as discussed on the next page.)

## POWER SUPPLY SELECTION

The AD570/AD571 are designed for optimum performance using $\mathrm{a}+5 \mathrm{~V}$ and -15 V supply, for which the J and S grades
are specified. AD571K will also operate with up to a +15 V supply, which allows direct interface to CMOS logic.


AD570/AD571 Functional Block Diagram

## CONNECTING THE AD570/AD571 FOR STANDARD OPERATION

The AD570/AD571 contain all the active components required to perform a complete A/D conversion. Thus, for most situations, all that is necessary is connection of the power supply ( +5 and -15 ), the analog input, and the conversion start pulse. The functional pin outs are shown below.


AD570 Pin Connections AD571 Pin Connections

## FEATURES

## Complete 10-Bit A/D Converter with Reference, Clock and Comparator

Full 8- or 16-Bit Microprocessor Bus Interface
Fast Successive Approximation Conversion - 20 $\boldsymbol{\mu}$ s typ
No Missing Codes Over Temperature
Operates on +5 V and -12 V to -15 V Supplies
Low Cost Monolithic Construction

## PRODUCT DESCRIPTION

The AD573 is a complete 10 -bit successive approximation analog to digital converter consisting of a DAC, voltage reference, clock, comparator, successive approximation register (SAR) and 3 state output buffers-all fabricated on a single chip. No external components are required to perform a full accuracy 10 -bit conversion in $20 \mu \mathrm{~s}$.
The AD573 incorporates advanced integrated circuit design and processing technologies. The successive approximation function is implemented with $\mathrm{I}^{2} \mathrm{~L}$ (integrated injection logic). Laser trimming of the high stability SiCr thin film resistor ladder network insures high accuracy, which is maintained with a temperature compensated sub-surface Zener reference.
Operating on supplies of +5 V and -12 V to -15 V , the AD573 will accept analog inputs of 0 to +10 V or -5 V to +5 V . The trailing edge of a positive pulse on the CONVERT line initiates the $20 \mu \mathrm{~s}$ conversion cycle. $\overline{\text { DATA }} \overline{\text { READY }}$ indicates completion of the conversion. $\overline{\text { HIGH }} \overline{\text { BYTE }} \overline{\text { ENABLE }}(\overline{\mathrm{HBE}})$ and $\overline{\text { LOW }}$ $\overline{\text { BYTE }} \overline{\text { ENABLE }}(\overline{\mathrm{LBE}})$ control the 8 -bit and 2-bit three state output buffers.
The AD573 is available in two versions for the 0 to $+70^{\circ} \mathrm{C}$ temperature range, the AD573J and AD573K. The AD573S guarantees $\pm 1$ LSB relative accuracy and no missing codes from $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
Three package configurations are offered. All versions are offered in a 20 -pin hermetically sealed ceramic DIP. The AD573J and AD573K are also available in a 20 -pin plastic DIP or 20 -pin leaded chip carrier. and 4,400,690

## FUNCTIONAL BLOCK DIAGRAM



## PRODUCT HIGHLIGHTS

1. The AD573 is a complete 10 -bit A/D converter. No external components are required to perform a conversion.
2. The AD573 interfaces to many popular microprocessors without external buffers or peripheral interface adapters. The 10 bits of output data can be read as a 10 -bit word or as 8 and 2-bit words.
3. The device offers true 10 -bit accuracy and exhibits no missing codes over its entire operating temperature range.
4. The AD573 adapts to either unipolar ( 0 to +10 V ) or bipolar ( -5 V to +5 V ) analog inputs by simply grounding or opening a single pin.
5. Performance is guaranteed with +5 V and -12 V or -15 V supplies.
6. The AD573 is available in a version compliant with MIL-STD883. Refer to the Analog Devices Military Products Databook or current /883B datasheet for detailed specifications.

AD573 - SPECIFICATIONS $\begin{gathered}\left(T_{A}=25 V, V+=+5 V, V-=-12 V\right. \\ \text { or }-15 V \text {, all voltages measured with respect }\end{gathered}$ to digital common, unless otherwise indicated.)


## NOTES

${ }^{1}$ Relative accuracy is defined as the deviation of the code transition points from the ideal transfer point on a
straight line from the zero to the full scale of the device.
${ }^{2}$ Full-scale calibration is guaranteed trimmable to zero with an external $50 \Omega$ potentiometer in place of the $15 \Omega$
fixed resistor. Full scale is defined as 10 volts minus 1LSB, or 9.990 volts.
${ }^{3}$ Defined as the resolution for which no missing codes will occur.
${ }^{4} \mathrm{Change}$ from $+25^{\circ} \mathrm{C}$ value from $+25^{\circ} \mathrm{C}$ to $\mathrm{T}_{\text {min }}$ or $\mathrm{T}_{\text {max }}$.
${ }^{5}$ The data output lines have active pull-ups to source 0.5 mA . The DATA READY line is open collector with a nominal $6 \mathbf{k} \Omega$ internal pull-up resistor.
Specifications subject to change without notice.
Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.
ABSOLUTE MAXIMUM RATINGS
V + to Digital Common . . . . . . . . . . . . . . 0 to +7 V
V - to Digital Common . . . . . . . . . . . . . 0 to -16.5 V
Analog Common to Digital Common . . . . . . . . . . $\pm 1 \mathrm{~V}$
Analog Input to Analog Common . . . . . . . . . . . $\pm 15 \mathrm{~V}$
Control Inputs . . . . . . . . . . . . . . . . . . . . 0 to V +
Digital Outputs (High Impedance State) . . . . . . . 0 to V +
Power Dissipation . . . . . . . . . . . . . . . . . . 800mW

ORDERING GUIDE ${ }^{1}$

| Model | Package Option ${ }^{2}$ | Temperature <br> Range | Relative <br> Accuracy |
| :--- | :--- | :--- | :--- |
| AD573JN | 20-Pin Plastic DIP(N-20) | 0 to $+70^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ max |
| AD573KN | 20-Pin Plastic DIP(N-20) | 0 to $+70^{\circ} \mathrm{C}$ | $\pm 1 / 2 \mathrm{LSB}$ max |
| AD573JP | 20-Pin Leaded ChipCarrier (P-20A) | 0 to $+70^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ max |
| AD573KP | 20-Pin Leaded ChipCarrier (P-20A) | 0 to $+70^{\circ} \mathrm{C}$ | $\pm 1 / 2 \mathrm{LSB} \max$ |
| AD573JD | 20-Pin Ceramic DIP(D-20) | 0 to $+70^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ max |
| AD573KD | 20-Pin Ceramic DIP(D-20) | 0 to $+70^{\circ} \mathrm{C}$ | $\pm 1 / 2 \mathrm{LSB}$ max |
| AD573SD | 20-Pin Ceramic DIP(D-20) | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB} \max$ |

NOTES
${ }^{1}$ For details on grade and package offerings screened in accordance with MIL-STD-883, refer to Analog Devices Military Products Databook.
${ }^{2} \mathrm{D}=$ Ceramic DIP; N = Plastic DIP; $\mathrm{P}=$ Plastic Leaded Chip Carrier. For outline information see Package Information section.


Figure 1. AD573 Functional Block Diagram


Figure 2. AD573 Pin Connections

## FEATURES

Complete 12-Bit A/D Converter with Reference and Clock
8- and 16-Bit Microprocessor Bus Interface
Guaranteed Linearity Over Temperature
0 to $+70^{\circ} \mathrm{C}$ - AD574AJ, K, L
$-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ - AD574AS, $\mathrm{T}, \mathrm{U}$
No Missing Codes Over Temperature
$\mathbf{3 5} \boldsymbol{\mu}$ s Maximum Conversion Time
Buried Zener Reference for Long-Term Stability and Low Gain T.C. $10 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ max AD574AL 12.5ppm/ ${ }^{\circ} \mathrm{C} \max$ AD574AU

Ceramic DIP, Plastic DIP or PLCC Package
Available in Higher Speed, Pinout-Compatible Versions ( $15 \mu \mathrm{~s}$ AD674B, $8 \mu \mathrm{~s}$ AD774B; 10 $\mu \mathrm{s}$ (with SHA) AD1674)
Available in Versions Compliant with MIL-STD-883 and JAN QPL.

## PRODUCT DESCRIPTION

The AD574A is a complete 12 -bit successive-approximation analog-to-digital converter with 3 -state output buffer circuitry for direct interface to an 8- or 16-bit microprocessor bus. A high-precision voltage reference and clock are included on-chip, and the circuit guarantees full-rated performance without external circuitry or clock signals.
The AD574A design is implemented using Analog Devices' Bipolar $/ \mathrm{I}^{2} \mathrm{~L}$ process, and integrates all analog and digital functions on one chip. Offset, linearity and scaling errors are minimized by active laser-trimming of thin-film resistors at the wafer stage. The voltage reference uses an implanted buried Zener for low noise and low drift. On the digital side, $\mathrm{I}^{2} \mathrm{~L}$ logic is used for the successive-approximation register, control circuitry and 3-state output buffers.
The AD574A is available in six different grades. The AD574AJ, K , and L grades are specified for operation over the 0 to $+70^{\circ} \mathrm{C}$ temperature range. The AD574AS, T, and U are specified for the $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ range. All grades are available in a 28 -pin hermetically-sealed ceramic DIP. Also, the J, K, and L grades are available in a 28 -pin plastic DIP and PLCC, and the J and K grades are available in ceramic LCC.
The S, T, and U grades in ceramic DIP or LCC are available with optional processing to MIL-STD-883C Class B; the T and U grades are available as JAN QPL. The Analog Devices' Military Products Databook should be consulted for details on /883B testing of the AD574A.

[^2]

## PRODUCT HIGHLIGHTS

1. The AD574A interfaces to most 8 - or 16 -bit microprocessors. Multiple-mode three-state output buffers connect directly to the data bus while the read and convert commands are taken from the control bus. The 12 bits of output data can be read either as one 12 -bit word or as two 8 -bit bytes (one with 8 data bits, the other with 4 data bits and 4 trailing zeros).
2. The precision, laser-trimmed scaling and bipolar offset resistors provide four calibrated ranges: 0 to +10 and 0 to +20 volts unipolar, -5 to +5 and -10 to +10 volts bipolar. Typical bipolar offset and full-scale calibration errors of $\pm 0.1 \%$ can be trimmed to zero with one external component each.
3. The internal buried Zener reference is trimmed to 10.00 volts with $0.2 \%$ maximum error and $15 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ typical T.C. The reference is available externally and can drive up to 1.5 mA beyond the requirements of the reference and bipolar offset resistors.
4. AD674B $(15 \mu \mathrm{~s})$ and AD774B ( $8 \mu \mathrm{~s}$ ) provide higher speed, pin compatibility; AD1674 ( $10 \mu \mathrm{~s}$ ) includes on-chip SampleHold Amplifier (SHA).

[^3]
AD574A


## NOTES

${ }^{1}$ Detailed Timing Specifications appear in the Timing Section.
${ }^{2} 12 / \overline{8}$ Input is not TTL-compatible and must be hard wired to $V_{\text {LOGIC }}$ or Digital Common.
${ }^{3}$ The reference should be buffered for operation on $\pm 12 \mathrm{~V}$ supplies.
${ }^{4} \mathrm{D}=$ Ceramic DIP; N = Plastic DIP; P = Plastic Leaded ChipCarrier. For outline information see Package Information section. Specifications subject to change without notice.


## NOTES

${ }^{1}$ Detailed Timing Specifications appear in the Timing Section.
${ }^{2} 12 / 8$ Input is not TTL-compatible and must be hard wired to $V_{\text {LOGIC }}$ or Digital Common.
${ }^{3}$ The reference should be buffered for operation on $\pm 12 \mathrm{~V}$ supplies.
${ }^{4} \mathrm{D}=$ Ceramic DIP. For outline information see Package Information section.
Specifications subject to change without notice.


AD574A Block Diagram and Pin Configuration

## ABSOLUTE MAXIMUMRATINGS*

(Specifications apply to all grades, except where noted)


ORDERING GUIDE

| Model ${ }^{1}$ | Temperature Range | Linearity Error <br> $\operatorname{Max}^{\left(\mathrm{T}_{\text {min }}\right.}$ to $\mathrm{T}_{\text {max }}$ ) | Resolution <br> No Missing Codes <br> ( $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ ) | Max <br> Full Scale <br> T.C. (ppm/ ${ }^{\circ} \mathrm{C}$ ) |
| :---: | :---: | :---: | :---: | :---: |
| AD574AJ(X) | 0 to $+70^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ | 11 Bits | 50.0 |
| AD574AK(X) | 0 to $+70^{\circ} \mathrm{C}$ | $\pm 1 / 2 \mathrm{LSB}$ | 12 Bits | 27.0 |
| AD574AL(X) | 0 to $+70^{\circ} \mathrm{C}$ | $\pm 1 / 2$ LSB | 12 Bits | 10.0 |
| AD574AS(X) ${ }^{2}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ | 11 Bits | 50.0 |
| AD574AT(X) ${ }^{2}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ | 12 Bits | 25.0 |
| AD574AU(X) ${ }^{2}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ | 12 Bits | 12.5 |

## NOTES

${ }^{1} \mathbf{X}=$ Package designator. Available packages are:
D (D-28) for all grades.
$E$ (E-28A) for $J$ and $K$ grades and $/ 883 B$ processed $S, T$ and $U$ grades.
N (N-28) for J, K, and L grades.
$\mathbf{P}(\mathbf{P}-28 \mathrm{~A})$ for PLCC in J, K grades.
Example: AD574AKN is K grade in plastic DIP.
${ }^{2}$ For details on grade and package offerings screened in accordance with MIL-STD-883, refer to Analog Devices Military Products Databook.

## FEATURES

Complete 8-Bit Signal Conditioning A/D Converter Including Instrumentation Amp and Reference Microprocessor Bus Interface<br>$10 \mu$ s Conversion Speed<br>Flexible Input Stage: Instrumentation Amp Front End Provides Differential Inputs and High Common-Mode Rejection<br>No User Trims Required<br>No Missing Codes Over Temperature<br>Single +5V Supply Operation<br>Convenient Input Ranges<br>20-Pin DIP or Surface-Mount Package<br>Low Cost Monolithic Construction<br>MIL-STD-883B Compliant Versions Available

## GENERAL DESCRIPTION

The AD670 is a complete 8-bit signal conditioning analog-to-digital converter. It consists of an instrumentation amplifier front end along with a DAC, comparator, successive approximation register (SAR), precision voltage reference, and a three-state output buffer on a single monolithic chip. No external components or user trims are required to interface, with full accuracy, an analog system to an 8 -bit data bus. The AD670 will operate on the +5 V system supply. The input stage provides differential inputs with excellent common-mode rejection and allows direct interface to a variety of transducers.
The device is configured with input scaling resistors to permit two input ranges: 0 to 255 mV ( $1 \mathrm{mV} / \mathrm{LSB}$ ) and 0 to 2.55 V ( $10 \mathrm{mV} / \mathrm{LSB}$ ). The AD670 can be configured for both unipolar and bipolar inputs over these ranges. The differential inputs and common-mode rejection of this front end are useful in applications such as conversion of transducer signals superimposed on commonmode voltages.
The AD670 incorporates advanced circuit design and proven processing technology. The successive approximation function is implemented with $\mathrm{I}^{2} \mathrm{~L}$ (integrated injection logic). Thin-film SiCr resistors provide the stability required to prevent missing codes over the entire operating temperature range while laser wafer trimming of the resistor ladder permits calibration of the device to within $\pm 1$ LSB. Thus, no user trims for gain or offset are required. Conversion time of the device is $10 \mu \mathrm{~s}$.

## FUNCTIONAL BLOCK DIAGRAM



The AD670 is available in four package types and five grades. The J and K grades are specified over 0 to $+70^{\circ} \mathrm{C}$ and come in 20-pin plastic DIP packages or 20-terminal PLCC packages. The $A$ and $B$ grades $\left(-40^{\circ} \mathrm{C}\right.$ to $\left.+85^{\circ} \mathrm{C}\right)$ and the S grade $\left(-55^{\circ} \mathrm{C}\right.$ to $+125^{\circ} \mathrm{C}$ ) come in 20 -pin ceramic DIP packages.
The S grade is also available with optional processing to MIL-STD883 in 20-pin ceramic DIP or 20 -terminal LCC packages. The Analog Devices Military Products Databook should be consulted for detailed specifications.

## PRODUCT HIGHLIGHTS

1. The AD670 is a complete 8 -bit A/D including three-state outputs and microprocessor control for direct connection to 8 -bit data buses. No external components are required to perform a conversion.
2. The flexible input stage features a differential instrumentation amp input with excellent common-mode rejection. This allows direct interface to a variety of transducers without preamplification.
3. No user trims are required for 8 -bit accurate performance.
4. Operation from a single +5 V supply allows the AD670 to run off of the microprocessor's supply.
5. Four convenient input ranges (two unipolar and two bipolar) are available through internal scaling resistors: 0 to 255 mV ( $1 \mathrm{mV} / \mathrm{LSB}$ ) and 0 to 2.55 V ( $10 \mathrm{mV} / \mathrm{LSB}$ ).
6. Software control of the output mode is provided. The user can easily select unipolar or bipolar inputs and binary or 2's complement output codes.

[^4]

| to $\mathrm{T}_{\text {max }}$ | GUARANTEED NO MISSING CODES ALL GRA |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| GAIN ACCURACY $\begin{aligned} & @+25^{\circ} \mathrm{C} \\ & \mathrm{~T}_{\min } \text { to } \mathrm{T}_{\max } \end{aligned}$ |  | $\begin{aligned} & \pm 1.5 \\ & \pm 2.0 \end{aligned}$ |  | $\begin{aligned} & \pm 0.75 \\ & \pm 1.0 \end{aligned}$ | $\begin{aligned} & \text { LSB } \\ & \text { LSB } \end{aligned}$ |
| UNIPOLAR ZERO ERROR $\begin{aligned} & @+25^{\circ} \mathrm{C} \\ & \mathrm{~T}_{\min } \text { to } \mathrm{T}_{\max } \end{aligned}$ |  | $\begin{aligned} & \pm 1.5 \\ & \pm 2.0 \end{aligned}$ |  | $\begin{aligned} & \pm 0.75 \\ & \pm 1.0 \end{aligned}$ | $\begin{aligned} & \text { LSB } \\ & \text { LSB } \end{aligned}$ |
| BIPOLAR ZERO ERROR $\begin{aligned} & @+25^{\circ} \mathrm{C} \\ & \mathrm{~T}_{\text {min }} \text { to } \mathrm{T}_{\text {max }} \end{aligned}$ |  | $\begin{aligned} & \pm 1.5 \\ & \pm 2.0 \end{aligned}$ |  | $\begin{aligned} & \pm 0.75 \\ & \pm 1.0 \end{aligned}$ | $\begin{aligned} & \text { LSB } \\ & \text { LSB } \end{aligned}$ |
| ANALOG INPUT RANGES <br> DIFFERENTIAL $\left(-V_{\text {IN }}\right.$ to $\left.+V_{\text {IN }}\right)$ <br> Low Range <br> High Range <br> ABSOLUTE (Inputs to Power Gnd) <br> Low Range $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ <br> High Range $T_{\text {min }}$ to $T_{\text {max }}$ | $\begin{aligned} & -0.150 \\ & -1.50 \end{aligned}$ | $\begin{array}{ll} 0 \text { to }+255 & \\ -128 \text { to }+127 & \\ 0 \text { to }+2.55 & \\ -1.28 \text { to }+1.27 & \\ & \\ & \mathbf{V}_{\mathrm{CC}}-3.4 \\ & \mathrm{~V}_{\mathrm{CC}} \end{array}$ | $\begin{array}{lr}  & 0 \text { to }+ \\ & -128 \\ & 0 \text { to }+ \\ & -1.2 \\ -\mathbf{0 . 1 5 0} & \\ -1.50 & \end{array}$ | $\begin{aligned} & \mathbf{v}_{\mathbf{C C}}-\mathbf{3 . 4} \\ & \mathbf{v}_{\mathrm{CC}} \end{aligned}$ | $\begin{aligned} & \mathrm{mV} \\ & \mathrm{mV} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \end{aligned}$ |
| BIAS CURRENT (255mV RANGE) <br> $T_{\text {min }}$ to $T_{\text {max }}$ | . | $200 \quad 500$ | 200 | 500 | nA |
| OFFSET CURRENT (255mV RANGE) <br> $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ | . | $40 \quad 200$ | 40 | 200 | nA |
| 2.55V RANGE INPUT RESISTANCE | 8.0 | 12.0 | 8.0 | 12.0 | $\mathrm{k} \Omega$ |
| 2.55V RANGE FULL SCALE MATCH + AND - INPUT |  | $\pm 1 / 2$ | $\pm 1 / 2$ |  | LSB |
| COMMON-MODE REJECTION RATIO ( 255 mV RANGE) | * | 1 |  | 1 | LSB |
| COMMON-MODE REJECTION RATIO(2.55V RANGE) |  | 1 | . | 1 | LSB |
| POWER SUPPLY <br> Operating Range <br> Current I ${ }_{\text {CC }}$ <br> Rejection Ratio $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ | 4.5 |  5.5 <br> 30 45 <br>  0.015 | $4.5$ $30$ | $\begin{aligned} & 5.5 \\ & 45 \\ & 0.015 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~mA} \\ & \% \text { of } \mathrm{FS} / \% \end{aligned}$ |
| ```DIGITALOUTPUTS SINK CURRENT \(\left(\mathrm{V}_{\text {OUT }}=0.4 \mathrm{~V}\right)\) \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) SOURCECURRENT \(\left(V_{\text {OUT }}=2.4 \mathrm{~V}\right)\) \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}^{\prime}\)``` | $\begin{aligned} & 1.6 \\ & 0.5 \end{aligned}$ |  | $\begin{aligned} & 1.6 \\ & 0.5 \end{aligned}$ |  | mA <br> mA |
| THREE-STATE LEAKAGECURRENT |  | $\pm 40$ | $\cdot$ | $\pm 40$ | $\mu \mathrm{A}$ |
| OUTPUT CAPACITANCE | -.. | 5 | 5 |  | pF |
| DIGITAL INPUT VOLTAGE $\mathbf{V}_{\text {INL }}$ $V_{\text {INH }}$ | $2.0$ | 0.8 | 2.0 | 0.8 | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |
| DIGITAL INPUTCURRENT $\begin{gathered} \left(0 \leq \mathrm{V}_{\mathrm{IN}} \leq+5 \mathrm{~V}\right) \\ \mathrm{I}_{\mathrm{INL}} \\ \mathrm{I}_{\mathrm{INH}} \end{gathered}$ | -100 | +100 | -100 | $+100$ | $\mu \mathrm{A}$ $\mu \mathrm{A}$ |
| INPUTCAPACITANCE | .. | 10 | 10 |  | pF |

## NOTES

${ }^{1}$ Tested at $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}, 5.0 \mathrm{~V}$ and 5.5 V .
Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.
Specifications subject to change without notice.

AD670


## NOTES

${ }^{1}$ Tested at $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}, 5.0 \mathrm{~V}$ and 5.5V for $\mathrm{A}, \mathrm{B}$ grades; 4.75V,5.0V and 5.5V for S grade.
Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.
Specifications subject to change without notice.


Figure 1. AD670 Block Diagram and Terminal Configuration (All Packages)

## ABSOLUTE MAXIMUM RATINGS*

$V_{C C}$ to Ground 0 V to +7.5 V
Digital Inputs (Pins 11-15) . . . . . . -0.5 V to $\mathrm{V}_{\mathrm{CC}}+0.5 \mathrm{~V}$
Digital Outputs (Pins 1-9) . Momentary Short to $\mathrm{V}_{\mathrm{CC}}$ or Ground
Analog Inputs (Pins 16-19) . . . . . . . . . . -30 V to +30 V
Power Dissipation . . . . . . . . . . . . . . . . . . . 450 mW
Storage Temperature Range . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10sec) . . . . . . . . . $+300^{\circ} \mathrm{C}$
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## ORDERING GUIDE

|  | Temperature <br> Range | Relative Accuracy <br> $@+25^{\circ} \mathrm{C}$ | Gain Accuracy <br> $@+25^{\circ} \mathrm{C}$ |  |
| :--- | :--- | :--- | :--- | :--- |
| Podel $^{1}$ |  |  |  |  |

[^5]
## FEATURES

## 12-Bit Resolution

24-Pin "Skinny DIP" Package
Conversion Time: 500 ns max - AD671J/K/S-500
750 ns max - AD671J/K/S-750
Low Power: 475 mW
Unipolar ( 0 to $+5 \mathrm{~V}, 0$ to +10 V ) and Bipolar Input Ranges ( $\pm 5 \mathrm{~V}$ )
Twos Complement or Offset Binary Output Data Out of Range Indicator
MIL-STD-883 Compliant Versions Available

## PRODUCT DESCRIPTION

The AD671 is a high speed monolithic 12-bit A/D converter offering conversion rates of up to 2 MHz ( 500 ns conversion time). The combination of a merged high speed bipolar/CMOS process and a novel architecture results in a combination of speed and power consumption far superior to previously available hybrid implementations. Additionally, the greater reliability of monolithic construction offers improved system reliability and lower costs than hybrid designs.
The AD671 uses a subranging flash conversion technique, with digital error correction for possible errors introduced in the first part of the conversion cycle. An on-chip timing generator provides strobe pulses for each of the four internal flash cycles and assures adequate settling time for the interflash residue amplifier. A single ENCODE pulse is used to control the converter.
The performance of the AD671 is made possible by using high speed, low noise bipolar circuitry in the linear sections and low power CMOS for the logic sections. Analog Devices' ABCMOS-1 process provides both high speed bipolar and 2-micron CMOS devices on a single chip. Laser trimmed thin-film resistors are used to provide accuracy and temperature stability.
The AD671 is available in two conversion speeds and performance grades. The AD671J and K grades are specified for operation over the 0 to $+70^{\circ} \mathrm{C}$ temperature range. The AD671S grades are specified for operation over the $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ temperature range. All grades are available in a 0.300 inch wide 24 -pin ceramic DIP. The J and K grades are also available in a 24-pin plastic DIP.

## FUNCTIONAL BLOCK DIAGRAM



## PRODUCT HIGHLIGHTS

1. The AD671 offers a single chip 2 MHz analog-to-digital conversion function in a space saving 24-pin DIP.
2. Input signal ranges are 0 to +5 V and 0 to +10 V unipolar, and -5 V to +5 V bipolar, selected by pin strapping. Input resistance is $1.5 \mathrm{k} \Omega$. Power supplies are +5 V and -5 V , and typical power consumption is less than 500 mW .
3. The external +5 V reference can be chosen to suit the dc accuracy and temperature drift requirements of the application.
4. Output data is available in unipolar, bipolar offset or bipolar twos complement binary format.
5. An OUT OF RANGE output bit indicates when the input signal is beyond the AD671's input range.
6. The AD671 is available in versions compliant with the MIL-STD-883. Refer to the Analog Devices Military Products Databook or current AD671/883B data sheet for detailed specifications.
 unless otherwise indicated)

| Parameter | AD671J/S-500 |  |  | AD671K-500 |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max |  |
| RESOLUTION | 12 |  |  | 12 |  |  | Bits |
| ACCURACY ( $+25^{\circ} \mathrm{C}$ ) |  |  |  |  |  |  |  |
| Integral Noniinearity (INL) |  |  |  |  |  |  |  |
| Differential Nonlinearity (DNL) |  |  |  |  |  |  |  |
| $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ | 10 |  |  | 11 |  |  | Bits |
| No Missing Codes |  | 10 Bits Guar |  |  | 11 Bits Guara |  |  |
| Unipolar Offset ${ }^{1}$ |  |  | $\pm 4$ |  |  | $\pm 4$ | LSB |
| Bipolar Zero ${ }^{1}$ |  |  | $\pm 10$ |  |  | $\pm 10$ | LSB |
| Gain Error ${ }^{2}$ |  | 0.1 | 0.25 |  | 0.1 | 0.25 | \% FSR |
| TEMPERATURE COEFFICIENTS ${ }^{3}$ |  |  |  |  |  |  |  |
| Unipolar Offset |  |  | $\pm 10$ |  |  | $\pm 10$ | ppm $/{ }^{\circ} \mathrm{C}$ |
| Bipolar Zero |  |  | $\pm 15$ |  |  | $\pm 15$ | ppm/ ${ }^{\circ} \mathrm{C}$ |
| Gain Error |  |  | $\pm 20$ |  |  | $\pm 20$ | ppm $/{ }^{\circ} \mathrm{C}$ |
| ANALOG INPUT |  |  |  |  |  |  |  |
| Input Ranges |  |  |  |  |  |  |  |
| Bipolar | -5 |  | +5 | -5 |  | +5 | Volts |
| Unipolar | 0 |  | +5 | 0 |  | +5 | Volts |
|  | 0 |  | +10 | 0 |  | +10 | Volts |
| Input Resistance |  |  |  |  |  |  |  |
| 10 Volt Range | 1.0 | 1.5 | 2.0 | 1.0 | 1.5 | 2.0 | k $\Omega$ |
| 5 Volt Range | 0.5 | 0.75 | 1.0 | 0.5 | 0.75 | 1.0 | $\mathrm{k} \Omega$ |
| Input Capacitance |  | 10 |  |  | 10 |  | pF |
| Reference Input Resistance | 2.4 | 3.5 | 4.7 | 2.4 | 3.5 | 4.7 | k $\Omega$ |
| POWER SUPPLIES |  |  |  |  |  |  |  |
| Power Supply Rejection ${ }^{4}$ |  |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{CC}}(+5 \mathrm{~V} \pm 0.25 \mathrm{~V})$ |  |  | $\pm 1$ |  |  | $\pm 1$ | LSB |
| $\mathrm{V}_{\text {LOGIC }}(+5 \mathrm{~V} \pm 0.5 \mathrm{~V})$ |  |  | $\pm 1$ |  |  | $\pm 1$ | LSB |
| $\mathrm{V}_{\mathrm{EE}}(-5 \mathrm{~V} \pm 0.25 \mathrm{~V})$ |  |  | $\pm 1$ |  |  | $\pm 1$ | LSB |
| Operating Voltages |  |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{CC}}$ | +4.75 |  | +5.25 | +4.75 |  | +5.25 | Volts |
| $\mathrm{V}_{\text {LoGIC }}$ | +4.5 |  | +5.5 | +4.5 |  | +5.5 | Volts |
| $\mathrm{V}_{\text {EE }}$ | -5.25 |  | -4.75 | -5.25 |  | -4.75 | Volts |
| Operating Current |  |  |  |  |  |  |  |
| $\mathrm{I}_{\mathrm{CC}}$ |  | 46 | 56 |  | 46 | 56 | mA |
| $\mathrm{I}_{\text {LOGIC }}{ }^{5}$ |  | 3 | 6 |  | 3 | 6 | mA |
| $\mathrm{I}_{\text {EE }}$ |  | 46 | 56 |  | 46 | 56 | mA |
| POWER CONSUMPTION |  | 475 | 621 |  | 475 | 621 | mW |
| TEMPERATURE RANGE |  |  |  |  |  |  |  |
| Specified (J/K) | 0 |  | +70 | 0 |  | +70 | ${ }^{\circ} \mathrm{C}$ |
| (S) | -55 |  | +125 |  |  |  | ${ }^{\circ} \mathrm{C}$ |

## NOTES

${ }^{1}$ Adjustable to zero with external potentiometers. See Offset/Gain Calibration section for additional information.
${ }^{2}$ Full-scale range (FSR) is 5 V for the 0 V to 5 V range and 10 V for the 0 V to 10 V and -5 V to +5 V ranges.
${ }^{3} 25^{\circ} \mathrm{C}$ to $\mathrm{T}_{\text {MIN }}$ and $25^{\circ} \mathrm{C}$ to $\mathrm{T}_{\text {MAX }}$.
${ }^{4}$ Change in gain error as a function of the dc supply voltage.
${ }^{5}$ Tested under static conditions.
Specifications subject to change without notice.
Specifications shown in boldface are tested on all devices at final electrical test with worst case supply voltages at $0,+25^{\circ} \mathrm{C}$ and $+70^{\circ} \mathrm{C}$. Results from those tests are used to calculate outgoing quality levels. All $\min$ and max specifications are guaranteed, although only those shown in boldface are tested.

## AD671-SPECIFICATIONS

DC SPECIFCCATIONS
$\left(\mathrm{T}_{\text {MIN }}\right.$ to $\mathrm{T}_{\text {MAX }}$ with $\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\text {Logic }}=+5 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{\mathrm{EE}}=-5 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\text {REF }}=+5.000 \mathrm{~V}$, unless otherwise indicated)


## NOTES

${ }^{1}$ Adjustable to zero with external potentiometers. See Offset/Gain Calibration section for further information.
${ }^{2}$ Full-scale range (FSR) is 5 V for the 0 V to 5 V range and 10 V for the 0 V to 10 V and -5 V to +5 V ranges.
${ }^{3} 25^{\circ} \mathrm{C}$ to $\mathrm{T}_{\text {MIN }}$ and $25^{\circ} \mathrm{C}$ to $\mathrm{T}_{\text {MAX }}$.
${ }^{4}$ Change in gain error as a function of the dc supply voltage.
${ }^{5}$ Tested under static conditions.
Specifications subject to change without notice.
Specifications shown in boldface are tested on all devices at final electrical test with worst case supply voltages at $0,+25^{\circ} \mathrm{C}$ and $+70^{\circ} \mathrm{C}$. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested.


| Parameter | Symbol | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| LOGIC INPUT |  |  |  |  |  |
| High Level Input Voltage | $\mathrm{V}_{\mathrm{IH}}$ | +2.0 |  |  | v |
| Low Level Input Voltage | $\mathrm{V}_{\text {IL }}$ |  |  | +0.8 | V |
| High Level Input Current ( $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {LOGIC }}$ ) | $\mathrm{I}_{\mathrm{IH}}$ | -10 |  | +10 | $\mu \mathrm{A}$ |
| Low Level Input Current ( $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ ) | $\mathrm{I}_{\text {IL }}$ | -10 |  | +10 | $\mu \mathrm{A}$ |
| Input Capacitance | $\mathrm{C}_{\text {IN }}$ |  | 5 |  | pF |
| LOGIC OUTPUTS |  |  |  |  |  |
| High Level Output Voltage ( $\mathrm{I}_{\mathrm{OH}}=0.5 \mathrm{~mA}$ ) | $\mathrm{V}_{\text {OH }}$ | +2.4 |  |  | V |
| Low Level Output Voltage ( $\mathrm{I}_{\text {OL }}=1.6 \mathrm{~mA}$ ) | $\mathrm{V}_{\text {OL }}$ |  |  | +0.4 | V |
| Output Capacitance | Cout |  | 5 |  | pF |

Specifications shown in boldface are tested on all devices at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested.
Specifications subject to change without notice.

, $\mathrm{V}_{\mathrm{L}}=0.8 \mathrm{~V}, V_{\mathrm{H}}=2.0 \mathrm{~V}, V_{\mathrm{OL}}=0.4 \mathrm{~V}$ and $\left.\mathrm{VH}_{\mathrm{O}}=2.4 \mathrm{~V}\right)$

| Parameter | Symbol | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Conversion Time |  |  |  |  |  |
| (AD671-500) | $\mathrm{t}_{\mathrm{C}}$ |  | 475 | 500 | ns |
| (AD671-750) | $\mathrm{t}_{\mathrm{C}}$ |  | 725 | 750 | ns |
| ENCODE Pulse Width High . |  |  |  |  |  |
| (AD671-500) | $\mathrm{t}_{\text {ENC }}$ | 20 |  | 30 | ns |
| (AD671-750) | $\mathrm{t}_{\text {ENC }}$ | 20 |  | 50 | ns |
| ENCODE Pulse Width Low | $\mathrm{t}_{\text {ENCL }}$ | 20 |  |  | ns |
| DAV Pulse Width |  |  |  |  |  |
| (AD671-500) | $\mathrm{t}_{\text {DAV }}$ | 75 |  | 200 | ns |
| (AD671-750) | $\mathrm{t}_{\text {dav }}$ | 75 |  | 300 | ns |
| ENCODE Falling Edge Delay | $\mathrm{t}_{\mathrm{F}}$ | 0 |  |  | ns |
| Start New Conversion Delay | $\mathrm{t}_{\mathrm{R}}$ |  |  |  | ns |
| Data and OTR Delay from DAV Falling Edge | $\mathrm{t}_{\text {DD }}{ }^{1}$ | 20 | 75 |  | ns |
| $\underline{\text { Data and OTR Valid before DAV Rising Edge }}$ | $\mathrm{tss}^{2}$ | 20 | 75 |  | ns |

NOTES
${ }^{1}{ }_{t}{ }_{\text {DD }}$ is measured from when the falling edge of DAV crosses 0.8 V to when the output crosses 0.4 V or 2.4 V with a 25 pF load capacitor on each output pin.
${ }^{2} \mathrm{t}_{\text {ss }}$ is measured from when the outputs cross 0.4 V or 2.4 V to when the rising edge of DAV crosses 2.4 V with a 25 pF load capacitor on each output pin.


Figure 1. AD671 Timing Diagrams

ABSOLUTE MAXIMUM RATINGS*

| Parameter | With <br> Respect <br> to | Min | Max | Units |
| :--- | :--- | :--- | :--- | :--- |
| $\mathrm{V}_{\mathrm{CC}}$ | ACOM | -0.5 | +6.5 | Volts |
| $\mathrm{V}_{\text {EE }}$ | ACOM | -6.5 | +0.5 | Volts |
| $\mathrm{V}_{\text {LOGIC }}$ | DCOM | -0.5 | +6.5 | Volts |
| ACOM | DCOM | -1.0 | +1.0 | Volts |
| $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{V}_{\text {LOGIC }}$ | -6.5 | +6.5 | Volts |
| ENCODE | DCOM | -0.5 | $\mathrm{~V}_{\text {LOGIC }}+0.5$ | Volts |
| REF IN | ACOM | -0.5 | $\mathrm{~V}_{\text {CC }}+0.5$ | Volts |
| AIN, BPO/UPO | ACOM | -6.5 | 11.0 | Volts |
| Junction Temperature |  |  | +175 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature |  | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |
| Lead Temperature $(10 \mathrm{sec})$ |  | +300 |  | ${ }^{\circ} \mathrm{C}$ |
| Power Dissipation |  |  | 1000 | mW |

*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum ratings for extended periods may effect device reliability.

ORDERING GUIDE

| Model $^{\mathbf{1}}$ | Linearity | Temperature <br> Range | Package <br> Options |
| :--- | :--- | :--- | :--- |
| AD671JD-500 | $\pm 4 \mathrm{LSB}$ | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{D}-24 \mathrm{~A}$ |
| AD671KD-500 | $\pm 2 \mathrm{LSB}$ | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{D}-24 \mathrm{~A}$ |
| AD671JD-750 | $\pm 2 \mathrm{LSB}$ | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{D}-24 \mathrm{~A}$ |
| AD671KD-750 | $\pm 1.5 \mathrm{LSB}$ | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{D}-24 \mathrm{~A}$ |
| AD671SD-500 | $\pm 4 \mathrm{LSB}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{D}-24 \mathrm{~A}$ |
| AD671SD-750 | $\pm 2.5 \mathrm{LSB}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{D}-24 \mathrm{~A}$ |

## NOTES

${ }^{1}$ For details on grade and package offerings screened in accordance with MIL-STD-883, refer to the Analog Devices Military Products Databook or current AD671/883 data sheet.
${ }^{2} \mathrm{D}=$ Ceramic DIP. For outline information see Package Information section.

## CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are inserted.


## FEATURES

Complete 8-Bit A/D Converter with Reference, Clock and Comparator<br>30 $\boldsymbol{\mu s}$ s Maximum Conversion Time<br>Full 8- or 16-Bit Microprocessor Bus Interface Unipolar and Bipolar Inputs<br>No Missing Codes Over Temperature<br>Operates on +5 V and -12 V to -15 V Supplies<br>MIL-STD-883 Compliant Version Available

## PRODUCT DESCRIPTION

The AD673 is a complete 8-bit successive approximation analog-todigital converter consisting of a DAC, voltage reference, clock, comparator, successive approximation register (SAR) and 3 state output buffers-all fabricated on a single chip. No external components are required to perform a full accuracy 8 -bit conversion in $20 \mu \mathrm{~s}$.

The AD673 incorporates advanced integrated circuit design and processing technologies. The successive approximation function is implemented with $I^{2} L$ (integrated injection logic). Laser trimming of the high stability SiCr thin film resistor ladder network insures high accuracy, which is maintained with a temperature compensated sub-surface Zener reference.
Operating on supplies of +5 V and -12 V to -15 V , the AD673 will accept analog inputs of 0 to +10 V or -5 V to +5 V . The trailing edge of a positive pulse on the CONVERT line initiates the $20 \mu \mathrm{~s}$ conversion cycle. $\overline{\mathrm{DATA}} \overline{\text { READY }}$ indicates completion of the conversion.
The AD673 is available in two versions. The AD673J as specified over the 0 to $+70^{\circ} \mathrm{C}$ temperature range and the AD673S guarantees $\pm 1 / 2 \mathrm{LSB}$ relative accuracy and no missing codes from $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
Two package configurations are offered. All versions are also offered in a 20 -pin hermetically sealed ceramic DIP. The AD673J is also available in a 20 -pin plastic DIP.

[^6]FUNCTIONAL BLOCK DIAGRAM


## PRODUCT HIGHLIGHTS

1. The AD673 is a complete 8 -bit $\mathrm{A} / \mathrm{D}$ converter. No external components are required to perform a conversion.
2. The AD673 interfaces to many popular microprocessors without external buffers or peripheral interface adapters.
3. The device offers true 8 -bit accuracy and exhibits no missing codes over its entire operating temperature range.
4. The AD673 adapts to either unipolar ( 0 to +10 V ) or bipolar ( -5 V to +5 V ) analog inputs by simply grounding or opening a single pin.
5. Performance is guaranteed with +5 V and -12 V or -15 V supplies.
6. The AD673 is available in a version compliant with MIL-STD883. Refer to the Analog Devices Military Products Databook or current AD673/883B data sheet for detailed specifications.

ORDERING GUIDE

| Model | Temperature <br> Range | Relative <br> Accuracy | Package Option ${ }^{1}$ |
| :--- | :--- | :--- | :--- |
| AD673JN | 0 to $+70^{\circ} \mathrm{C}$ | $\pm 1 / 2$ LSB max | Plastic DIP(N-20) |
| AD673JD | 0 to $+70^{\circ} \mathrm{C}$ | $\pm 1 / 2$ LSB max | Ceramic DIP(D-20) |
| AD673SD ${ }^{2}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\pm 1 / 2$ LSB max | Ceramic DIP(D-20) |
| AD673JP | 0 to $+70^{\circ} \mathrm{C}$ | $\pm 1 / 2$ LSB max | PLCC(P-20A) |

## NOTES

${ }^{2}$ D $=$ Ceramic DIP; N = Plastic DIP; $\mathbf{P}=$ Plastic Leaded Chip Carrier. For outline information see Package Information section.
${ }^{2}$ For details on grade and package offering screened in accordance with MIL-STD-883, refer to the Analog Devices Military Products Databook. respect to digital common, unless otherwise noted.)

| Model | Min | AD67 Typ | Max | Min | AD67 <br> Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| RESOLUTION . .n.men |  | 8 |  |  | 8 |  | Bits |
| $\begin{aligned} & \text { RELATIVE ACCURACY, } \\ & \mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\min } \text { to } \mathrm{T}_{\max } \end{aligned}$ |  |  | $\begin{aligned} & \pm 1 / 2 \\ & \pm 1 / 2 \end{aligned}$ |  |  | $\begin{aligned} & \pm 1 / 2 \\ & \pm 1 / 2 \end{aligned}$ | $\begin{aligned} & \text { LSB } \\ & \text { LSB } \end{aligned}$ |
| FULL SCALE CALIBRATION ${ }^{2}$ |  | $\pm 2$ |  |  | $\pm 2$ |  | LSB |
| UNIPOLAR OFFSET |  |  | $\pm 1 / 2$ |  |  | $\pm 1 / 2$ | LSB |
| BIPOLAR OFFSET |  |  | $\pm 1 / 2$ |  |  | $\pm 1 / 2$ | LSB |
| DIFFERENTIAL NONLINEARITY, ${ }^{3}$ $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\min } \text { to } \mathrm{T}_{\text {max }}$ |  |  |  |  |  |  | $\begin{aligned} & \text { Bits } \\ & \text { Bits } \end{aligned}$ |
| TEMPERATURE RANGE | 0 |  | + 70 | -55 |  | $+125$ | ${ }^{\circ} \mathrm{C}$ |
| TEMPERATURE COEFFICIENTS <br> Unipolar Offset <br> Bipolar Offset <br> Full ScaleCalibration ${ }^{2}$ |  |  | $\begin{aligned} & \pm 1 \\ & \pm 1 \\ & \pm 2 \end{aligned}$ |  |  | $\begin{aligned} & \pm 1 \\ & \pm 1 \\ & \pm 2 \end{aligned}$ | $\begin{aligned} & \text { LSB } \\ & \text { LSB } \\ & \text { LSB } \end{aligned}$ |
| POWER SUPPLY REJECTION <br> Positive Supply $+4.5 \leq V+\leq+5.5 \mathrm{~V}$ <br> Negative Supply $\begin{aligned} & -15.75 \mathrm{~V} \leq \mathrm{V}-\leq-14.25 \mathrm{~V} \\ & -12.6 \mathrm{~V} \leq \mathrm{V}-\leq-11.4 \mathrm{~V} \end{aligned}$ |  |  | $\begin{aligned} & \pm 2 \\ & \pm 2 \\ & \pm 2 \end{aligned}$ |  |  | $\begin{aligned} & \pm 2 \\ & \pm 2 \\ & \pm 2 \end{aligned}$ | $\begin{aligned} & \text { LSB } \\ & \text { LSB } \\ & \text { LSB } \end{aligned}$ |
| ANALOG INPUT IMPEDANCE | 3.0 | 5.0 | 7.0 | 3.0 | 5.0 | 7.0 | k $\Omega$ |
| ANALOG INPUT RANGES Unipolar Bipolar | $\begin{aligned} & 0 \\ & -5 \\ & \hline \end{aligned}$ |  | $\begin{aligned} & +10 \\ & +5 \end{aligned}$ | $\begin{aligned} & 0 \\ & -5 \end{aligned}$ |  | $\begin{aligned} & +10 \\ & +5 \end{aligned}$ | $\begin{aligned} & \mathbf{v} \\ & \mathbf{v} \end{aligned}$ |
| OUTPUTCODING <br> Unipolar <br> Bipolar | Positive <br> Positive | $\begin{aligned} & \text { rue } \mathrm{Bin} \\ & \text { rue Off } \end{aligned}$ |  | Positive Positive | $\begin{aligned} & \text { rue } \mathrm{Bin} \\ & \text { rue Off } \end{aligned}$ |  |  |
| LOGICOUTPUT <br> Output Sink Current <br> ( $\mathrm{V}_{\text {OUT }}=0.4 \mathrm{~V}$ max, $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ ) <br> Output Source Current ${ }^{4}$ <br> ( $\mathrm{V}_{\text {OUT }}=2.4 \mathrm{~V} \min , \mathrm{~T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ ) <br> Output Leakage | $\begin{aligned} & 3.2 \\ & 0.5 \end{aligned}$ |  | $\pm 40$ | $\begin{aligned} & 3.2 \\ & 0.5 \end{aligned}$ |  | $\pm 40$ | mA <br> mA <br> $\mu \mathrm{A}$ |
| LOGIC INPUTS Input Current Logic " 1 " Logic " 0 " | 2.0 |  | $\begin{aligned} & \pm 100 \\ & 0.8 \end{aligned}$ | 2.0 |  | $\begin{aligned} & \pm 100 \\ & 0.8 \end{aligned}$ | $\begin{aligned} & \mu \mathrm{A} \\ & \mathbf{V} \\ & \mathbf{V} \end{aligned}$ |
| CONVERSION TIME, $\mathrm{T}_{\mathrm{A}}$ and $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ | 10 | 20 | 30 | 10 | 20 | 30 | $\mu \mathrm{s}$ |
| $\begin{aligned} & \text { POWER SUPPLY } \\ & \mathrm{V}+_{+} \\ & \mathrm{v}- \\ & \hline \end{aligned}$ | $\begin{aligned} & +4.5 \\ & -11.4 \end{aligned}$ | $\begin{aligned} & +5.0 \\ & -15 \end{aligned}$ | $\begin{aligned} & +7.0 \\ & -16.5 \end{aligned}$ | $\begin{aligned} & +4.5 \\ & -11.4 \end{aligned}$ | $\begin{aligned} & +5.0 \\ & -15 \end{aligned}$ | $\begin{aligned} & +7.0 \\ & -16.5 \end{aligned}$ |  |
| OPERATING CURRENT $\begin{aligned} & \mathrm{V}+ \\ & \mathrm{V}- \end{aligned}$ |  | $\begin{aligned} & 15 \\ & 9 \end{aligned}$ | $\begin{array}{r} 20 \\ 15 \end{array}$ |  | $\begin{aligned} & 15 \\ & 9 \end{aligned}$ | $\begin{aligned} & 20 \\ & 15 \end{aligned}$ | $\begin{aligned} & \mathrm{mA} \\ & \mathrm{~mA} \end{aligned}$ |

## NOTES

${ }^{1}$ Relative accuracy is defined as the deviation of the code transition points from the ideal transfer point on a
straight line from the zero to the full scale of the device.
${ }^{2}$ Full scale calibration is guaranteed trimmable to zero with an external $200 \Omega$ potentiometer in place of the $15 \Omega$.
fixed resistor.
Full scale is defined as 10 volts minus 1LSB, or 9.961 volts.
${ }^{3}$ Defined as the resolution for which no missing codes will occur.
${ }^{4}$ The data output lines have active pull-ups to source 0.5 mA . The DATA READY line is open collector with a nominal $6 \mathrm{k} \Omega$ internal pull-up resistor.
Specifications subject to change without notice.
Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.

## FEATURES

Complete Monolithic 12-Bit A/D Converters with Reference, Clock, and Three-State Output Buffers Industry Standard Pinout<br>High Speed Upgrades for AD574A<br>8- and 16-Bit Microprocessor Interface<br>$8 \mu \mathrm{~s}$ (max) Conversion Time (AD774B)<br>$15 \mu s$ (max) Conversion Time (AD674B)<br>$\pm 5 \mathrm{~V}, \pm 10 \mathrm{~V}, 0-10 \mathrm{~V}, 0-20 \mathrm{~V}$ Input Ranges<br>Commercial, Industrial and Military Temperature Range Grades<br>MIL-STD-883 Compliant Versions Available

## PRODUCT DESCRIPTION

The AD674B and AD774B are complete 12-bit successiveapproximation analog-to-digital converters with three-state output buffer circuitry for direct interface to 8 - and 16 -bit microprocessor busses. A high precision voltage reference and clock are included on chip, and the circuit requires only power supplies and control signals for operation.
The AD674B and AD774B are pin compatible with the industrystandard AD574A, but offer faster conversion time and busaccess speed than the AD574A and lower power consumption. The AD674B converts in $15 \mu$ (maximum) and the AD774B converts in $8 \mu \mathrm{~s}$ (maximum).
The monolithic design is implemented using Analog Devices' BiMOS II process allowing high performance bipolar analog circuitry to be combined on the same die with digital CMOS logic. Offset, linearity and scaling errors are minimized by active lasertrimming of thin-film resistors.

Five different grades are available. The J and K grades are specified for operation over the $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ temperature range. The A and B grades are specified from $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$, the T grade is specified from $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. The J and K grades are available in a 28 -pin plastic DIP or 28 -lead SOIC. All other grades are available in a 28 -pin hermetically sealed ceramic DIP.
*Protected by U.S. Patent Nos. 4,250,445; 4,808,908; RE30586.

FUNCTIONAL BLOCK DIAGRAM


## PRODUCT HIGHLIGHTS

1. Industry Standard Pinout: The AD674B and AD774B utilize the pinout established by the industry standard AD574A.
2. Analog Operation: The precision, laser-trimmed scaling and bipolar offset resistors provide four calibrated ranges: 0 to +10 V and 0 to +20 V unipolar; -5 V to +5 V and -10 V to +10 V bipolar. The AD674B and AD774B operate on +5 V and $\pm 12 \mathrm{~V}$ or $\pm 15 \mathrm{~V}$ power supplies.
3. Flexible Digital Interface: On-chip multiple-mode three-state output buffers and interface logic allow direct connection to most microprocessors. The 12 bits of output data can be read either as one 12 -bit word or as two 8 -bit bytes (one with 8 data bits, the other with 4 data bits and 4 trailing zeros).
4. The internal reference is trimmed to 10.00 volts with $1 \%$ maximum error and $10 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ typical temperature coefficient. The reference is available externally and can drive up to 2.0 mA beyond the requirements of the converter and bipolar offset resistors.
5. The AD674B and AD774B are available in versions compliant with MIL-STD-883. Refer to the Analog Devices Military Products Databook or current AD674B/AD774B data sheet for detailed specifications.

[^7]$A D 674 B / A D 77 A B-S P E G|F| G A T O N S$
$V_{\text {LOGIC }}=+5 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{\text {EE }}=-15 \mathrm{~V} \pm 10 \%$ or $-12 \mathrm{~V} \pm 5 \%$ unless otherwise indicated) $\mathrm{T}_{\text {Max }}$ with $\mathrm{V}_{\mathrm{CC}}=+15 \mathrm{~V} \pm 10 \%$ or $+12 \mathrm{~V} \pm 5 \%$,

| Model (AD674B or AD774B) | Min | J Grade Typ | Max | Min | K Grade Typ | Max |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| RESOLUTION |  |  | 12 |  |  | 12 |
| LINEARITY ERROR @ $+25^{\circ} \mathrm{C}$ <br> $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |  |  | $\begin{aligned} & \pm 1 \\ & \pm 1 \end{aligned}$ | $\cdots$ |  | $\begin{aligned} & \pm 1 / 2 \\ & \pm 1 / 2 \end{aligned}$ |
| DIFFERENTIAL LINEARITY ERROR <br> (Minimum Resolution for Which No Missing Codes are Gudianteed) | 12 |  |  | 12 |  |  |
| UNIPOLAR OFFSET ${ }^{1} @+25^{\circ} \mathrm{C}$ |  |  | $\pm 2$ |  |  | $\pm 2$ |
| BIPOLAR OFFSET ${ }^{1}$ @ +25 ${ }^{\circ} \mathrm{C}$ |  |  | $\pm 6$ |  |  | $\pm 3$ |
| FULL-SCALE CALIBRATION ERROR ${ }^{1,2} @+25^{\circ} \mathrm{C}$ (with Fixed $50 \Omega$ Resistor from REF OUT to REF IN) |  | 0.1 | 0.25 |  | 0.1 | 0.125 |
| TEMPERATURE RANGE | 0 |  | +70 | 0 |  | +70 |
| TEMPERATURE DRIFT ${ }^{3}$ <br> (Using Internal Reference) Unipolar Bipolar Offset Full-Scale Calibration |  |  | $\begin{aligned} & \pm 2 \\ & \pm 2 \\ & \pm 6 \end{aligned}$ |  |  | $\begin{aligned} & \pm 1 \\ & \pm 1 \\ & \pm 2 \end{aligned}$ |
| POWER SUPPLY REJECTION <br> Max Change in Full-Scale Calibration $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=15 \mathrm{~V} \pm 1.5 \mathrm{~V} \text { or } 12 \mathrm{~V} \pm 0.6 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{LOGIC}}=5 \mathrm{~V} \pm 0.5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{EE}}=-15 \mathrm{~V} \pm 1.5 \mathrm{~V} \text { or }-12 \mathrm{~V} \pm 0.6 \mathrm{~V} \end{aligned}$ |  |  | $\begin{aligned} & \pm 2 \\ & \pm 1 / 2 \\ & \pm 2 \end{aligned}$ |  |  | $\begin{aligned} & \pm 1 \\ & \pm 1 / 2 \\ & \pm 1 \end{aligned}$ |
| ANALOG INPUT Input Ranges Bipolar Unipolar | $\begin{aligned} & -5 \\ & -10 \\ & 0 \\ & 0 \end{aligned}$ |  | $\begin{aligned} & +5 \\ & +10 \\ & +10 \\ & +20 \end{aligned}$ | $\begin{aligned} & -5 \\ & -10 \\ & 0 \\ & 0 \end{aligned}$ |  | $\begin{aligned} & +5 \\ & +10 \\ & +10 \\ & +20 \end{aligned}$ |
| Input Impedance 10 Volt Span 20 Volt Span | $\begin{aligned} & 3 \\ & 6 \end{aligned}$ | $\begin{aligned} & 5 \\ & 10 \end{aligned}$ | $\begin{aligned} & 7 \\ & 14 \end{aligned}$ | $\begin{aligned} & 3 \\ & 6 \end{aligned}$ | $\begin{aligned} & 5 \\ & 10 \end{aligned}$ | $\begin{aligned} & 7 \\ & 14 \end{aligned}$ |
| POWER SUPPLIES <br> Operating Range <br> $V_{\text {LOGIC }}$ <br> $V_{C C}$ <br> $\mathrm{V}_{\mathrm{EE}}$ | $\begin{aligned} & +4.5 \\ & +11.4 \\ & -16.5 \end{aligned}$ |  | $\begin{aligned} & +5.5 \\ & +16.5 \\ & -11.4 \end{aligned}$ | $\begin{aligned} & +4.5 \\ & +11.4 \\ & -16.5 \end{aligned}$ |  | $\begin{aligned} & +5.5 \\ & +16.5 \\ & -11 . \end{aligned}$ |
| $\begin{aligned} & \text { Operating Current } \\ & \mathrm{I}_{\mathrm{LOGIC}} \\ & \mathrm{I}_{\mathrm{CC}} \\ & \mathrm{I}_{\mathrm{EE}} \end{aligned}$ |  | $\begin{aligned} & 3.5 \\ & 3.5 \\ & 10 \end{aligned}$ | $\begin{aligned} & 7 \\ & 7 \\ & 14 \end{aligned}$ |  | $\begin{aligned} & 3.5 \\ & 3.5 \\ & 10 \end{aligned}$ | $\begin{aligned} & 7 \\ & 7 \\ & 14 \end{aligned}$ |
| POWER CONSUMPTION |  | $\begin{aligned} & 220 \\ & 175 \end{aligned}$ | 375 |  | $\begin{aligned} & 220 \\ & 175 \end{aligned}$ | 375 |
| INTERNAL REFERENCE VOLTAGE <br> Output Current (Available for External Loads) (External Load Should Not Change During the Conversion) | 9.9 | 10.0 | $\begin{aligned} & 10.1 \\ & 2.0 \end{aligned}$ | 9.9 | 10.0 | $\begin{aligned} & 10.1 \\ & 2.0 \end{aligned}$ |

[^8]

AD674B/AD774B
DIGITAL SPECIFICATIONS
(for all grades $\mathrm{T}_{\text {MII }}$ to $\mathrm{T}_{\text {max }}$, with $\mathrm{V}_{\text {cc }}=+15 \mathrm{~V} \pm 10 \%$ or $+12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\text {Logic }}=+5 \mathrm{~V} \pm 10 \%$, $V_{E E}=-15 \mathrm{~V} \pm 10 \%$ or $-12 \mathrm{~V} \pm 5 \%$ )

| Parameter | Test Conditions | Min | Max | Units |
| :---: | :---: | :---: | :---: | :---: |
| LOGIC INPUTS |  |  |  |  |
| $\mathrm{V}_{\text {IH }} \quad$ High Level Input Voltage |  | +2.0 | $\mathrm{V}_{\text {LOGIC }}+0.5 \mathrm{~V}$ | V |
| $\mathrm{V}_{\mathrm{IL}} \quad$ Low Level Input Voltage |  | -0.5 | +0.8 | V |
| $\mathrm{I}_{\mathrm{IH}} \quad$ High Level Input Current | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {LOGIC }}$ | -10 | +10 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{IL}} \quad$ Low Level Input Current | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}$ | -10 | +10 | $\mu \mathrm{A}$ |
| $\mathrm{C}_{\text {IN }} \quad$ Input Capacitance |  |  | 10 | pF |
| LOGIC OUTPUTS |  |  |  |  |
| $\mathrm{V}_{\mathrm{OH}} \quad$ High Level Output Voltage | $\mathrm{I}_{\mathrm{OH}}=0.5 \mathrm{~mA}$ | +2.4 |  | V |
| $\mathrm{V}_{\text {OL }}$ Low Level Output Voltage | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ |  | +0.4 | V |
| $\mathrm{I}_{\mathrm{Oz}} \quad$ High-Z Leakage Current | $\mathrm{V}_{\text {IN }}=0$ to $\mathrm{V}_{\text {LOGIC }}$ | -10 | +10 | $\mu \mathrm{A}$ |
| $\mathrm{C}_{\mathrm{OZ}} \quad$ High-Z Output Capacitance |  |  | 10 | pF |

## ABSOLUTE MAXIMUM RATINGS*

$\mathrm{V}_{\mathrm{CC}}$ to Digital Common . . . . . . . . . . . . . . . . . 0 to +16.5 V
$\mathrm{V}_{\mathrm{EE}}$ to Digital Common . . . . . . . . . . . . . . . . . 0 to -16.5 V
$\mathrm{V}_{\text {LOGIC }}$ to Digital Common . . . . . . . . . . . . . . . . . 0 to +7 V
Analog Common to Digital Common . . . . . . . . . . . . . . $\pm 1$ V
Digital Inputs to Digital Common . -0.5 V to $\mathrm{V}_{\text {LOGIC }}+0.5 \mathrm{~V}$
Analog Inputs to Analog Common . . . . . . . . . . $\mathrm{V}_{\mathrm{EE}}$ to $\mathrm{V}_{\mathrm{CC}}$
$20 \mathrm{~V}_{\text {IN }}$ to Analog Common . . . . . . . . . . . . . . . . . . . $\pm 24$ V
REF OUT . . . . . . . . . . . . . . . Indefinite Short to Common . . . . . . . . . . . . . . . . . Momentary Short to $\mathrm{V}_{\mathrm{CC}}$
Junction Temperature . . . . . . . . . . . . . . . . . . . . . . $+175^{\circ} \mathrm{C}$
Power Dissipation . . . . . . . . . . . . . . . . . . . . . . . . 825 mW
Lead Temperature, Soldering . . . . . . . . . . . . . $300^{\circ} \mathrm{C}$, 10 sec
Storage Temperature . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## PIN CONFIGURATION



ORDERING GUIDE

| Model $^{\mathbf{1}}$ | Temperature | Conversion <br> Time (max $)$ | INL <br> $\left(\mathbf{T}_{\text {min }}\right.$ to $\left.\mathbf{T}_{\text {max }}\right)$ | Package <br> Description | Package <br> Option ${ }^{2}$ |
| :--- | :--- | :--- | :--- | :--- | :--- |
| AD674BJN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $15 \mu \mathrm{~s}$ | $\pm 1 \mathrm{LSB}$ | Plastic DIP | $\mathrm{N}-28$ |
| AD674BKN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $15 \mu \mathrm{~s}$ | $\pm 1 / 2 \mathrm{LSB}$ | Plastic DIP | $\mathrm{N}-28$ |
| AD674BJR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $15 \mu \mathrm{~s}$ | $\pm 1 \mathrm{LSB}$ | Plastic SOIC | $\mathrm{R}-28$ |
| AD674BKR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $15 \mu \mathrm{~s}$ | $\pm 1 / 2 \mathrm{LSB}$ | Plastic SOIC | $\mathrm{R}-28$ |
| AD674BAD | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $15 \mu \mathrm{~s}$ | $\pm 1 \mathrm{LSB}$ | Ceramic DIP | $\mathrm{D}-28$ |
| AD674BBD | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $15 \mu \mathrm{~s}$ | $\pm 1 / 2 \mathrm{LSB}$ | Ceramic DIP | $\mathrm{D}-28$ |
| AD674BTD | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $15 \mu \mathrm{~s}$ | $\pm 1 \mathrm{LSB}$ | Ceramic DIP | $\mathrm{D}-28$ |
| AD774BJN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $8 \mu \mathrm{~s}$ | $\pm 1 \mathrm{LSB}$ | Plastic DIP | $\mathrm{N}-28$ |
| AD774BKN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $8 \mu \mathrm{~s}$ | $\pm 1 / 2 \mathrm{LSB}$ | Plastic DIP | $\mathrm{N}-28$ |
| AD774BJR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $15 \mu \mathrm{~s}$ | $\pm 1 \mathrm{LSB}$ | Plastic SOIC | $\mathrm{R}-28$ |
| AD774BKR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $15 \mu \mathrm{~s}$ | $\pm 1 / 2 \mathrm{LSB}$ | Plastic SOIC | $\mathrm{R}-28$ |
| AD774BAD | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $8 \mu \mathrm{~s}$ | $\pm 1 \mathrm{LSB}$ | Ceramic DIP | $\mathrm{D}-28$ |
| AD774BBD | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $8 \mu \mathrm{~s}$ | $\pm 1 / 2 \mathrm{LSB}$ | Ceramic DIP | $\mathrm{D}-28$ |
| AD774BTD | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $8 \mu \mathrm{~s}$ | $\pm 1 \mathrm{LSB}$ | Ceramic DIP | $\mathrm{D}-28$ |

NOTES
${ }^{1}$ For details on grade and package offerings screened in accordance with MIL-STD-883, refer to the Analog
Devices Military Products Databook or current AD674B/AD774B/883B data sheet.
${ }^{2} \mathbf{N}=$ Plastic DIP; D = Hermetic DIP; R = Plastic SOIC. For outline information see Package Information section.

## FEATURES

Autocalibrating<br>On-Chip Sample-Hold Function<br>Parallel Output Format<br>16 Bits No Missing Codes<br>$\pm 1$ LSB INL<br>-97 dB THD<br>$90 \mathrm{~dB} \mathrm{~S} /(\mathrm{N}+\mathrm{D})$<br>1 MHz Full Power Bandwidth

## PRODUCT DESCRIPTION

The AD676 is a multipurpose 16-bit parallel output analog-todigital converter which utilizes a switched-capacitor/charge redistribution architecture to achieve a 100 kSPS conversion rate ( $10 \mu \mathrm{~s}$ total conversion time). Overall performance is optimized by digitally correcting internal nonlinearities through on-chip autocalibration.

The AD676 circuitry is segmented onto two monolithic chips a digital control chip fabricated on Analog Devices DSP CMOS process and an analog ADC chip fabricated on our BiMOS II process. Both chips are contained in a single package.
The AD676 is specified for ac (or "dynamic") parameters such as $\mathrm{S} /(\mathrm{N}+\mathrm{D})$ Ratio, THD and IMD which are important in signal processing applications. In addition, dc parameters are specified which are important in measurement applications.

FUNCTIONAL BLOCK DIAGRAM


The AD676 operates from +5 V and $\pm 12 \mathrm{~V}$ supplies and typically consumes 360 mW during conversion. The digital supply $\left(\mathrm{V}_{\mathrm{DD}}\right)$ is separated from the analog supplies $\left(\mathrm{V}_{\mathrm{CC}}, \mathrm{V}_{\mathrm{EE}}\right)$ for reduced digital crosstalk. An analog ground sense is provided for the analog input. Separate analog and digital grounds are also provided.

The AD676 is available in a 28 -pin plastic DIP or 28 -pin sidebrazed ceramic package. A serial-output version, the AD677, is available in a 16 -pin 300 mil wide ceramic or plastic package.

## AD676-SPECIFICATIONS

AC SPECIFICATIONS $\left(T_{M L N} \text { to } T_{M A X}, V_{C C}=+12 V \pm 5 \%, V_{E E}=-12 \mathrm{~V} \pm 5 \%, V_{D D}=+5 \mathrm{~V} \pm 10 \%\right)^{1}$

| Parameter | AD676J/A |  |  | AD676K/B |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max |  |
| Total Harmonic Distortion (THD) ${ }^{2}$ |  |  |  |  |  |  |  |
| @ $83 \mathrm{kSPS}, \mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |  | -96 | -88 |  | -97 | -90 | dB |
|  |  | 0.0016 | 0.004 |  | 0.0014 | 0.003 | \% |
| (a) $100 \mathrm{kSPS},+25^{\circ} \mathrm{C}$ |  | -96 |  |  | -97 |  | dB |
|  |  | 0.0016 |  |  | 0.0014 |  | \% |
| @ $100 \mathrm{kSPS}, \mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |  | -92 |  |  | -92 |  | dB |
|  |  | 0.0025 |  |  | 0.0025 |  | \% |
| Signal-to-Noise and Distortion Ratio $(\mathrm{S} /(\mathrm{N}+\mathrm{D}))^{2,3}$ |  |  |  |  |  |  |  |
| (a) $83 \mathrm{kSPS}, \mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\mathrm{MAX}}$ | 85 | 89 |  | 87 | 90 |  | dB |
| (a) $100 \mathrm{kSPS},+25^{\circ} \mathrm{C}$ |  | 89 |  |  | 90 |  | dB |
| @ $100 \mathrm{kSPS}, \mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |  | 86 |  |  | 86 |  | dB |
| Peak Spurious or Peak Harmonic Component |  | -98 |  |  | -98 |  | dB |
| Intermodulation Distortion (IMD) ${ }^{4}$ |  |  |  |  |  |  |  |
| 2nd Order Products |  | -102 |  |  | -102 |  | dB |
| 3rd Order Products |  | -98 |  |  | -98 |  | dB |
| Full Power Bandwidth |  | 1 |  |  | 1 |  | MHz |
| Noise |  | 160 |  |  | 160 |  | $\mu \mathrm{V}$ rms |

DIGITAL SPECIFICATIONS (for all grades $T_{M I N}$ to $T_{\text {MAX }}, V_{C C}=+12 \mathrm{~V} \pm 5 \%, V_{E E}=-12 \mathrm{~V} \pm 5 \%, V_{D D}=+5 \mathrm{~V} \pm 10 \%$ )

| Parameter | Test Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| LOGIC INPUTS |  |  |  |  |  |
| $\mathrm{V}_{\text {IH }} \quad$ High-Level Input Voltage |  | 2.4 |  | $\mathrm{V}_{\mathrm{DD}}+0.3$ | V |
| $\mathrm{V}_{\text {IL }} \quad$ Low-Level Input Voltage |  | -0.3 |  | 0.8 | V |
| $\mathrm{I}_{\mathrm{IH}} \quad$ High-Level Input Current | $\mathrm{V}_{\mathrm{IH}}=\mathrm{V}_{\mathrm{DD}}$ | -10 |  | +10 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{IL}} \quad$ Low-Level Input Current | $\mathrm{V}_{\text {IL }}=0 \mathrm{~V}$ | -10 |  | +10 | $\mu \mathrm{A}$ |
| $\mathrm{C}_{\text {IN }} \quad$ Input Capacitance |  |  | 10 |  | pF |
| LOGIC OUTPUTS |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{OH}} \quad$ High-Level Output Voltage | $\mathrm{I}_{\mathrm{OH}}=0.1 \mathrm{~mA}$ | $\mathrm{V}_{\mathrm{DD}}-1 \mathrm{~V}$ |  |  | V |
|  | $=0.5 \mathrm{~mA}$ | 2.4 |  |  | V |
| $\mathrm{V}_{\text {OL }} \quad$ Low-Level Output Voltage | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ |  |  | 0.4 | V |

NOTES
${ }^{1} \mathrm{~V}_{\text {REF }}=10.0 \mathrm{~V}$, Conversion Rate $(\mathrm{fs})=83 \mathrm{kSPS}, \mathrm{f}_{\mathrm{IN}}=1.0 \mathrm{kHz}, \mathrm{V}_{\mathrm{IN}}=-0.05 \mathrm{~dB}$, Bandwidth $=\mathrm{fs} / 2$ unless otherwise indicated. All measurements referred to a $0 \mathrm{~dB}(20 \mathrm{~V}$ p-p) input signal. Values are post-calibration.
${ }^{2}$ For other input amplitudes, refer to Figure 13.
${ }^{3}$ For other input ranges/voltages reference values see Figure 12.
${ }^{4} \mathrm{fa}=1008 \mathrm{~Hz}, \mathrm{fb}=1055 \mathrm{~Hz}$. See Definition of Specifications section and Figure 15.
Specifications subject to change without notice.

DC SPECIFICATIONS $\left(\mathrm{T}_{\mathrm{MIN}} \text { to } \mathrm{T}_{\mathrm{MAX}}, \mathrm{V}_{\mathrm{CC}}=+12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{EE}}=-12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{DD}}=+5 \mathrm{~V} \pm 10 \%\right)^{1}$

| Parameter | AD676J/A |  |  | AD676K/B |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max |  |
| TEMPERATURE RANGE |  |  |  |  |  |  |  |
| J, K Grades | 0 |  | +70 | 0 |  | +70 | ${ }^{\circ} \mathrm{C}$ |
| A, B Grades | -40 |  | +85 | -40 |  | +85 | ${ }^{\circ} \mathrm{C}$ |
| ACCURACY |  |  |  |  |  |  |  |
| Resolution | 16 |  |  | 16 |  |  | Bits |
| Integral Nonlinearity (INL) |  |  |  |  |  |  |  |
| (a) $83 \mathrm{kSPS}, \mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |  | $\pm 1$ |  |  | $\pm 1$ | $\pm 1.5$ | LSB |
| ( $100 \mathrm{kSPS},+25^{\circ} \mathrm{C}$ |  | $\pm 1$ |  |  | $\pm 1$ |  | LSB |
| (a $100 \mathrm{kSPS}, \mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |  | $\pm 2$ |  |  | $\pm 2$ |  | LSB |
| Differential Nonlinearity (DNL)-No Missing Codes |  | 16 |  | 16 |  |  | Bits |
| Bipolar Zero Error ${ }^{2}$ (at Nominal Supplies) |  | 0.005 |  |  | 0.005 |  | \% FSR |
| Gain Error (at Nominal Supplies) |  |  |  |  |  |  |  |
| @ $83 \mathrm{kSPS}^{2}$ |  | 0.005 |  |  | 0.005 |  | \% FSR |
| (a) $100 \mathrm{kSPS},+25^{\circ} \mathrm{C}$ |  | 0.005 |  |  | 0.005 |  | \% FSR |
| (a) $100 \mathrm{kSPS}^{2}$ |  | 0.01 |  |  | 0.01 |  | \% FSR |
| Temperature Drift, Bipolar Zero ${ }^{3}$ |  |  |  |  |  |  | \% FSR |
| J, K Grades |  | 0.0015 |  |  | 0.0015 |  | \% FSR |
| A, B Grades |  | 0.003 |  |  | 0.003 |  | \% FSR |
| Temperature Drift, Gain ${ }^{3}$ |  |  |  |  |  |  |  |
| J, K Grades |  | 0.0015 |  |  | 0.0015 |  | \% FSR |
| A, B Grades |  | 0.003 |  |  | 0.003 |  | \% FSR |
| VOLTAGE REFERENCE INPUT RANGE ${ }^{4}$ ( $\mathrm{V}_{\text {REF }}$ ) | 5 |  | 10 | 5 |  | 10 | V |
| ANALOG INPUT ${ }^{5}$ |  |  |  |  |  |  |  |
| Input Range ( $\mathrm{V}_{\text {IN }}$ ) |  |  | $\pm \mathrm{V}_{\text {REF }}$ |  |  | $\pm \mathrm{V}_{\mathrm{REF}}$ | V |
| Input Impedance |  | * |  |  | * |  |  |
| Input Settling Time |  | 2 |  |  | 2 |  | $\mu \mathrm{s}$ |
| Input Capacitance During Sample |  |  | 50* |  |  | 50* | pF |
| Aperture Delay |  | 6 |  |  | 6 |  | ns |
| Aperture Jitter |  | 100 |  |  | 100 |  | ps |
| POWER SUPPLIES |  |  |  |  |  |  |  |
| Power Supply Rejection |  |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{CC}}=+12 \mathrm{~V} \pm 5 \%$ |  | $\pm 1$ |  |  | $\pm 1$ |  | LSB |
| $\mathrm{V}_{\mathrm{EE}}=-12 \mathrm{~V} \pm 5 \%$ |  | $\pm 1$ |  |  | $\pm 1$ |  | LSB |
| $\mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V} \pm 10 \%$ |  | $\pm 1$ |  |  | $\pm 1$ |  | LSB |
| Operating Current |  |  |  |  |  |  |  |
| $\mathrm{I}_{\mathrm{CC}}$ |  | 14.5 | 18 |  | 14.5 | 18 | mA |
| $\mathrm{I}_{\text {EE }}$ |  | 14.5 | 18 |  | 14.5 | 18 | mA |
| $\mathrm{I}_{\text {DD }}$ |  | 2 | 5 |  | 2 | 5 | mA |
| Power Consumption |  | 360 | 480 |  | 360 | 480 | mW |

## NOTES

${ }^{1} \mathrm{~V}_{\text {REF }}=5.0 \mathrm{~V}$, Conversion Rate $=83 \mathrm{kSPS}$ unless otherwise noted. Values are post-calibration.
${ }^{2}$ Values shown apply to any temperature from $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ after calibration at that temperature.
${ }^{3}$ Values shown are based upon calibration at $+25^{\circ} \mathrm{C}$ with no additional calibration at temperature. Values shown are the worst case variation from the value at $+25^{\circ} \mathrm{C}$
${ }^{4}$ See "APPLICATIONS" section for recommended voltage reference circuit, and Figure 12 for dynamic performance with other reference voltage values.
${ }^{\text {S}}$ See "APPLICATIONS" section for recommended input buffer circuit.
*For explanation of input characteristics, see "ANALOG INPUT" section.
Specifications subject to change without notice.

TIMING SPECIFICATIONS
$\left(\mathrm{T}_{\text {MIN }} \text { to } \mathrm{T}_{\text {MAX }}, \mathrm{V}_{\mathrm{CC}}=+12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{EE}}=-12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{DD}}=+5 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{\mathrm{REF}}=10.0 \mathrm{~V}\right)^{1}$

| Parameter | Symbol | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Conversion Time ${ }^{2}$ | $\mathrm{t}_{\mathrm{C}}$ | 10 |  | 1000 | $\mu \mathrm{s}$ |
| CLK Period ${ }^{3}$ | $\mathrm{t}_{\text {CLK }}$ | 480 |  |  | ns |
| Calibration Time | $\mathrm{t}_{\mathrm{CT}}$ |  |  | 85,530 | $\mathrm{t}_{\text {cLK }}$ |
| Sampling Time (Included in $\mathrm{t}_{\mathrm{C}}$ ) | $\mathrm{t}_{\text {s }}$ | 2 |  |  | $\mu \mathrm{s}$ |
| CAL to BUSY Delay | $\mathrm{t}_{\text {CALB }}$ |  | 75 | 150 | ns |
| BUSY to SAMPLE Delay | $\mathrm{t}_{\text {BS }}$ | 2 |  |  | $\mu \mathrm{S}$ |
| SAMPLE to BUSY Delay | $\mathrm{t}_{\text {SB }}$ |  | 15 | 100 | ns |
| CLK HIGH ${ }^{4}$ | $\mathrm{t}_{\mathrm{CH}}$ | 50 |  |  | ns |
| CLK LOW ${ }^{4}$ | $\mathrm{t}_{\mathrm{CL}}$ | 50 |  |  | ns |
| SAMPLE LOW to 1st CLK Delay | $\mathrm{t}_{\text {sc }}$ | 50 |  |  | ns |
| SAMPLE LOW | $\mathrm{t}_{\text {SL }}$ | 100 |  |  | ns |
| Output Delay | $\mathrm{t}_{\text {OD }}$ |  | 125 | 200 | ns |
| Status Delay | $\mathrm{t}_{\text {SD }}$ | 50 |  |  | ns |
| CAL HIGH Time | $\mathrm{t}_{\text {CALH }}$ | 50 |  |  | ns |

## NOTES

${ }^{1}$ See the "CONVERSION CONTROL" and "AUTOCALIBRATION" sections for detailed explanations of the above timing.
${ }^{2}$ Depends upon external clock frequency; includes acquisition time and conversion time. The maximum conversion time is specified to account for the droop of the internal sample/hold function. Longer conversion times may degrade performance. See "General Conversion Guidelines" for additional explanation of maximum conversion time.
${ }^{3} 580 \mathrm{~ns}$ is recommended for optimal accuracy over temperature.
${ }^{4} \mathrm{t}_{\mathrm{CII}}+\mathrm{t}_{\mathrm{CI}}=\mathrm{t}_{\mathrm{CLK}}$ and must be greater than 480 ns.


Figure 1. Calibration Timing


Figure 2a. General Conversion Timing


Figure 2b. Continuous Conversion Timing

## ORDERING GUIDE

| Model | Temperature Range | S/(N+D) | Max INL | Package Description | Package <br> Option $^{2}$ |
| :--- | :--- | :--- | :--- | :--- | :--- |
| AD676JD | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 85 dB |  | Ceramic 28-Pin DIP | D-28 |
| AD676KD | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 87 dB | $\pm 1.5 \mathrm{LSB}$ | Ceramic 28-Pin DIP | D-28 |
| AD676AD | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 85 dB |  | Ceramic 28-Pin DIP | D-28 |
| AD676BD | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 87 dB | $\pm 1.5 \mathrm{LSB}$ | Ceramic 28-Pin DIP | D-28 |

## NOTES

${ }^{1}$ For details on grade and package offerings screened in accordance with MIL-STD-883, refer to the AD676/883 data sheet. ${ }^{2} \mathrm{D}=$ Ceramic DIP. For outline information see Package Information section.

$$
\begin{aligned}
& \text { ABSOLUTE MAXIMUM RATINGS* }
\end{aligned}
$$

$$
\begin{aligned}
& \mathrm{V}_{\mathrm{Cc}} \text { to AGND . . . . . . . . . . . . . . . . . . . . }-0.3 \mathrm{~V} \text { to }+18 \mathrm{~V} \\
& \mathrm{~V}_{\mathrm{EE}} \text { to AGND . . . . . . . . . . . . . . . . . . . . }-18 \mathrm{~V} \text { to }+0.3 \mathrm{~V} \\
& \text { AGND to DGND . . . . . . . . . . . . . . . . . . . . . . . . } \pm 0.3 \mathrm{~V} \\
& \text { Digital Inputs to DGND . . . . . . . . . . . . . . . . . } 0 \text { to }+5.5 \mathrm{~V} \\
& \text { Analog Inputs, } \mathrm{V}_{\text {ReF }} \text { to AGND } \\
& \ldots . . . . . . . . . . . . . . . .\left(V_{\mathrm{CC}}+0.3 \mathrm{~V}\right) \text { to }\left(\mathrm{V}_{\mathrm{EE}}-0.3 \mathrm{~V}\right) \\
& \text { Soldering . . . . . . . . . . . . . . . . . . . . . . . . }+300^{\circ} \mathrm{C} \text {, } 10 \text { sec } \\
& \text { Storage Temperature . . . . . . . . . . . . . . . . }-65^{\circ} \mathrm{C} \text { to }+150^{\circ} \mathrm{C} \\
& \text { *Stresses greater than those listed under "Absolute Maximum Ratings". may } \\
& \text { cause permanent damage to the device. This is a stress rating only and } \\
& \text { functional operation of the device at these or any other conditions above those } \\
& \text { indicated in the operational section of this specification is not implied. } \\
& \text { Exposure to absolute maximum rating conditions for extended periods may } \\
& \text { affect device reliability. }
\end{aligned}
$$

## CAUTION

The AD676 features input protection circuitry consisting of large "distributed" diodes and polysilicon series resistors to dissipate both high energy discharges (Human Body Model) and fast, low energy pulses (Charged Device Model). Per Method 3015.2 of MIL-STD-883C, the AD676 has been classified as a Category 1 Device.
Proper ESD precautions are strongly recommended to avoid functional damage or performance degradation. Charges as high as 4000 volts readily accumulate on the human body and test equipment, and discharge without detection. Unused devices must be stored in conductive foam or shunts,
 and the foam discharged to the destination socket before devices are removed. For further information on ESD precaution, refer to Analog Devices' ESD Prevention Manual.

| Pin | Name | Type | Description |
| :---: | :---: | :---: | :---: |
| 1-6 | BIT 11-BIT 16 | DO | BIT 11-BIT 16 represent the six LSBs of data. |
| 7 | BUSY | DO | Status Line for Converter. Active HIGH, indicating a conversion or calibration in progress. BUSY should be buffered when capacitively loaded. |
| 8 | CAL | DI | Calibration Control Pin (Asynchronous). |
| 9 | SAMPLE | DI | $\mathrm{V}_{\text {IN }}$ Acquisition Control Pin. Active HIGH. During conversion, SAMPLE controls the state of the internal sample-hold amplifier and the falling edge initiates conversion (see "Conversion Control" paragraph). During calibration, SAMPLE should be held LOW. If HIGH during calibration, diagnostic information will appear on the two LSBs (Pins 5 and 6). |
| 10 | CLK | DI | Master Clock Input. The AD676 requires 17 clock cycles to execute a conversion. |
| 11 | DGND | P | Digital Ground. |
| 12 | $\mathrm{V}_{\mathrm{CC}}$ | P | +12 V Analog Supply Voltage. |
| 13 | AGND | P/AI | Analog Ground. |
| 14 | AGND SENSE | AI | Analog Ground Sense. |
| 15 | $\mathrm{V}_{\text {IN }}$ | AI | Analog Input Voltage. |
| 16 | $\mathrm{V}_{\text {REF }}$ | AI | External Voltage Reference Input. |
| 17 | $\mathrm{V}_{\text {EE }}$ | P | -12 V Analog Supply Voltage. Note: the lid of the ceramic package is internally connected to $\mathrm{V}_{\mathrm{EE}}$. |
| 18 | $\mathrm{V}_{\text {DD }}$ | P | +5 V Logic Supply Voltage. |
| 19-28 | BIT 1-BIT 10 | DO | BIT 1-BIT 10 represent the ten MSB of data. |

Type: $\quad \mathrm{AI}=$ Analog Input
DI $=$ Digital Input
DO = Digital Output
P = Power

| BIT $11 \square$ | $\checkmark$ | 28] BIT 10 |
| :---: | :---: | :---: |
| BIT 12 |  | 27 віт 9 |
| BIT $13 \bigcirc$ |  | 26 Віт 8 |
| BIT 144 |  | 25 BIT 7 |
| BIT 155 |  | 24 Bit 6 |
| BIT 16 (LSB) 6 |  | 23 BIT 5 |
| busy 7 | TOP VIEW | 22 Bit 4 |
| CAL 8 | (Not to Scale) | 21 віт 3 |
| sample 9 |  | 20 віт 2 |
| CLK 10 |  | 19 BIT 1 (MSB) |
| DGND 11 |  | 18 vDD |
| $\mathrm{V}_{\mathrm{cc}} 12$ |  | 17 veE |
| AGND 13 |  | $16 \mathrm{v}_{\text {feF }}$ |
| AGND SENSE 14 |  | 15 viN |



## NYQUIST FREQUENCY

An implication of the Nyquist sampling theorem, the "Nyquist frequency" of a converter is that input frequency which is one half the sampling frequency of the converter.

## TOTAL HARMONIC DISTORTION

Total harmonic distortion (THD) is the ratio of the rms sum of the harmonic components to the rms value of a full-scale input signal and is expressed in percent (\%) or decibels (dB). For input signals or harmonics that are above the Nyquist frequency, the aliased components are used.

## SIGNAL-TO-NOISE PLUS DISTORTION RATIO

Signal-to-noise plus distortion is defined to be the ratio of the rms value of the measured input signal to the rms sum of all other spectral components below the Nyquist frequency, including harmonics but excluding dc.

## GAIN ERROR

The last transition should occur at an analog value 1.5 LSB below the nominal full scale ( 4.99977 volts for a $\pm 5 \mathrm{~V}$ range). The gain error is the deviation of the actual difference between the first and last code transition from the ideal difference between the first and last code transition.

## BIPOLAR ZERO ERROR

Bipolar zero error is the difference between the ideal midscale input voltage ( 0 V ) and the actual voltage producing the midscale output code.

## DIFFERENTIAL NONLINEARITY (DNL)

In an ideal ADC, code transitions are one LSB apart. Differential nonlinearity is the maximum deviation from this ideal value. It is often specified in terms of resolution for which no missing codes are guaranteed.

## INTEGRAL NONLINEARITY (INL)

The ideal transfer function for an ADC is a straight line bisecting the center of each code drawn between "zero" and "full scale." The point used as "zero" occurs $1 / 2$ LSB before the most negative code transition. "Full scale" is defined as a level 1.5 LSB beyond the most positive code transition. Integral nonlinearity is the worst-case deviation of a code center average from the straight line.

## BANDWIDTH

The full-power bandwidth is that input frequency at which the amplitude of the reconstructed fundamental is reduced by 3 dB for a full-scale input.

## INTERMODULATION DISTORTION (IMD)

With inputs consisting of sine waves at two frequencies, fa and fb , any device with nonlinearities will create distortion products, of order ( $\mathbf{m}+\mathrm{n}$ ), at sum and difference frequencies of $\mathrm{mfa} \pm$ nfb , where $\mathrm{m}, \mathrm{n}=0,1,2,3 \ldots$ Intermodulation terms are those for which $m$ or $n$ is not equal to zero. For example, the second order terms are $(\mathrm{fa}+\mathrm{fb})$ and ( $\mathrm{fa}-\mathrm{fb}$ ), and the third order terms are ( $2 \mathrm{fa}+\mathrm{fb}$ ), ( $2 \mathrm{fa}-\mathrm{fb}$ ), (fa +2 fb ) and (fa 2 fb ). The IMD products are expressed as the decibel ratio of the rms sum of the measured input signals to the rms sum of the distortion terms. The two signals applied to the converter are of equal amplitude, and the peak value of their sum is -0.5 dB from full scale. The IMD products are normalized to a 0 dB input signal.

## APERTURE DELAY

Aperture delay is the time required after SAMPLE pin is taken LOW for the internal sample-hold of the AD676 to open, thus holding the value of $\mathrm{V}_{\mathrm{IN}}$.

## APERTURE JITTER

Aperture jitter is the variation in the aperture delay from sample to sample.

## POWER SUPPLY REJECTION

DC variations in the power supply voltage will affect the overall transfer function of the ADC, resulting in zero error and gain error changes. Power supply rejection is the maximum change in either the bipolar zero error or gain error value. Additionally, there is another power supply variation to consider. AC ripple on the power supplies can couple noise into the ADC, resulting in degradation of dynamic performance. This is displayed in Figure 16.

## INPUT SETTLING TIME

Settling time is a function of the SHA's ability to track fast slewing signals. This is specified as the maximum time required in track mode after a full-scale step input to guarantee rated conversion accuracy.

## FUNCTIONAL DESCRIPTION

The AD676 is a multipurpose 16 -bit analog-to-digital converter and includes circuitry which performs an input sample/hold function, ground sense, and autocalibration. These functions are segmented onto two monolithic chips - an analog signal processor and a digital controller. Both chips are contained within the AD676 package.
The AD676 employs a successive-approximation technique to determine the value of the analog input voltage. However, instead of the traditional laser-trimmed resistor-ladder approach, this device uses a capacitor-array, charge redistribution technique. Binary-weighted capacitors subdivide the input sample to perform the actual analog-to-digital conversion. The capacitor array eliminates variation in the linearity of the device due to temperature-induced mismatches of resistor values. Since a capacitor array is used to perform the data conversions, the sample/hold function is included without the need for additional external circuitry.
Initial errors in capacitor matching are eliminated by an autocalibration circuit within the AD676. This circuit employs an on-chip microcontroller and a calibration DAC to measure and compensate capacitor mismatch errors. As each error is determined, its value is stored in on-chip memory (RAM). Subsequent conversions use these RAM values to improve conversion accuracy. The autocalibration routine may be invoked at any time. Autocalibration insures high performance while eliminating the need for any user adjustments and is described in detail below.
The microcontroller controls all of the various functions within the AD676. These include the actual successive approximation algorithm, the autocalibration routine, the sample/hold operations, and the internal output data latch.

## AUTOCALIBRATION

The AD676 achieves rated performance without the need for user trims or adjustments. This is accomplished through the use of on-chip autocalibration.
In the autocalibration sequence, sample/hold offset is nulled by internally connecting the input circuit to the ground sense circuit. The resulting offset voltage is measured and stored in RAM for later use. Next, the capacitor representing the most significant bit (MSB) is charged to the reference voltage. This charge is then transferred to a capacitor of equal size (composed of the sum of the remaining lower weight bits). The difference in the voltage that results and the reference voltage represents the amount of capacitor mismatch. A calibration digital-toanalog converter (DAC) adds an appropriate value of error correction voltage to cancel this mismatch. This correction factor is also stored in RAM. This process is repeated for each of the capacitors representing the remaining top eight bits. The accumulated values in RAM are then used during subsequent conversions to adjust conversion results accordingly.
As shown in Figure 1, when CAL is taken HIGH the AD676 internal circuitry is reset, the BUSY pin is driven HIGH, and the ADC prepares for calibration. This is an asynchronous hardware reset and will interrupt any conversion or calibration currently in progress. Actual calibration begins when CAL is taken

LOW and completes in 85,530 clock cycles, indicated by BUSY going LOW. During calibration, it is preferable for SAMPLE to be held LOW. If SAMPLE is HIGH, diagnostic data will appear on Pins 5 and 6. This data is of no value to the user.

The AD676 requires one clock cycle after BUSY goes LOW to complete the calibration cycle. If this clock cycle is not provided, it will be taken from the first conversion, likely resulting in first conversion error.

In most applications, it is sufficient to calibrate the AD676 only upon power-up, in which case care should be taken that the power supplies and voltage reference have stabilized first. If not calibrated, the AD676 accuracy may be as low as 10 bits.

## CONVERSION CONTROL

The AD676 is controlled by two signals: SAMPLE and CLK, as shown in Figures 2a and 2b. It is assumed that the part has been calibrated and the digital I/O pins have the levels shown at the start of the timing diagram.
A conversion consists of an input acquisition followed by 17 clock pulses which execute the 16-bit internal successive approximation routine. The analog input is acquired by taking the SAMPLE line HIGH for a minimum sampling time of $\mathrm{t}_{\mathrm{s}}$. The actual sample taken is the voltage present on $\mathrm{V}_{\mathrm{IN}}$ one aperture delay after the SAMPLE line is brought LOW, assuming the previous conversion has completed (signified by BUSY going LOW). Care should be taken to ensure that this negative edge is well defined and jitter free in ac applications to reduce the uncertainty (noise) in signal acquisition. With SAMPLE going LOW, the AD676 commits itself to the conversion-the input at $\mathrm{V}_{\text {IN }}$ is disconnected from the internal capacitor array, BUSY goes HIGH, and the SAMPLE input will be ignored until the conversion is completed (when BUSY goes LOW). SAMPLE must be held LOW for a minimum period of time $t_{\text {SL }}$. A period of time $t_{s C}$ after bringing SAMPLE LOW, the 17 CLK cycles are applied; CLK pulses that start before this period of time are ignored. BUSY goes HIGH $\mathrm{t}_{\text {SB }}$ after SAMPLE goes LOW, signifying that a conversion is in process, and remains HIGH until the conversion is completed. BUSY goes LOW during the 17th CLK cycle at the point where the data outputs have changed and are valid. The AD676 will ignore CLK after BUSY has gone LOW and the output data will remain constant until a new conversion is completed. The data can, therefore, be read any time after BUSY goes LOW and before the 17th CLK of the next conversion (see Figures 2a and 2b). The section on Microprocessor Interfacing discusses how the AD676 can be interfaced to a 16 -bit databus.

Typically BUSY would be used to latch the AD676 output data into buffers or to interrupt microprocessors or DSPs. It is recommended that the capacitive load on BUSY be minimized by driving no more than a single logic input. Higher capacitive loads such as cables or multiple gates may degrade conversion quality unless BUSY is buffered.

## CONTINUOUS CONVERSION

For maximum throughput rate, the AD676 can be operated in a continuous convert mode (see Figure 2b). This is accomplished by utilizing the fact that SAMPLE will no longer be ignored after BUSY goes LOW, so an acquisition may be initiated even
during the HIGH time of the 17th CLK pulse for maximum throughput rate while enabling full settling of the sample/hold circuitry. If SAMPLE is already HIGH when BUSY goes LOW at the end of a conversion, then an acquisition is immediately initiated and $t_{\mathrm{S}}$ and $\mathrm{t}_{\mathrm{C}}$ start from that time. Data from the previous conversion may be latched up to $t_{S D}$ before BUSY goes LOW or $t_{O D}$ after the rising edge of the 17 th clock pulse. However, it is preferred that latching occur on or after the falling edge of BUSY.
Care must be taken to adhere to the minimum/maximum timing requirements in order to preserve conversion accuracy.

## GENERAL CONVERSION GUIDELINES

During signal acquisition and conversion, care should be taken with the logic inputs to avoid digital feedthrough noise. It is possible to run CLK continuously, even during the sample period. However, CLK edges during the sampling period, and especially when SAMPLE goes LOW, may inject noise into the sampling process. The AD676 is tested with no CLK cycles during the sampling period. The BUSY signal can be used to prevent the clock from running during acquisition, as illustrated in Figure 3. In this circuit BUSY is used to reset the circuitry which divides the system clock down to provide the AD676 CLK. This serves to interrupt the clock until after the input signal has been acquired, which has occurred when BUSY goes HIGH. When the conversion is completed and BUSY goes LOW, the circuit in Figure 3 truncates the 17th CLK pulse width which is tolerable because only its rising edge is critical.


Figure 3.
Figure 3 also illustrates the use of a counter ( 74 HC 393 ) to derive the AD676 SAMPLE command from the system clock when a continuous convert mode is desirable. Pin 9 (2QC) provides a 96 kHz sample rate for the AD676 when used with a 12.288 MHz system clock. Alternately, Pin 8 (2QD) could be used for a 48 kHz rate.
If a continuous clock is used, then the user must avoid CLK edges at the instant of disconnecting $\mathrm{V}_{\text {IN }}$ which occurs at the falling edge of SAMPLE (see $\mathrm{t}_{\mathrm{SC}}$ specification). The duty cycle of CLK may vary, but both the HIGH ( $\mathrm{t}_{\mathrm{CH}}$ ) and LOW ( $\mathrm{t}_{\mathrm{CL}}$ )
phases must conform to those shown in the timing specifications. The internal comparator makes its decisions on the rising edge of CLK. To avoid a negative edge transition disturbing the comparator's settling, $\mathrm{t}_{\mathrm{CL}}$ should be at least half the value of $t_{\text {CLK }}$. To also avoid transitions disturbing the internal comparator's settling, it is not recommended that the SAMPLE pin change state toward the end of a CLK cycle.
During a conversion, internal dc error terms such as comparator voltage offset are sampled, stored on internal capacitors and used to correct for their corresponding errors when needed. Because these voltages are stored on capacitors, they are subject to leakage decay and so require refreshing. For this reason there is a maximum conversion time $\mathrm{t}_{\mathrm{C}}(1000 \mu \mathrm{~s})$. From the time SAMPLE goes HIGH to the completion of the 17th CLK pulse, no more than $1000 \mu \mathrm{~s}$ should elapse for specified performance. However, there is no restriction to the maximum time between conversions.
Output coding for the AD676 is twos complement, as shown in Table I. By inverting the MSB, the coding can be converted to offset binary. The AD676 is designed to limit output coding in the event of out-of-range inputs.

Table 1. Output Coding

| $\mathbf{V}_{\text {IN }}$ | Output Code |
| :--- | :--- |
| $>$ Full Scale | $011 \ldots 11$ |
| Full Scale | $011 \ldots 11$ |
| Full Scale - 1 LSB | $011 \ldots 10$ |
| Midscale + 1 LSB | $000 \ldots 01$ |
| Midscale | $000 \ldots 00$ |
| Midscale - 1 LSB | $111 \ldots 11$ |
| -Full Scale + 1 LSB | $100 \ldots 01$ |
| -Full Scale | $100 \ldots 00$ |
| <-Full Scale | $100 \ldots 00$ |

## POWER SUPPLIES AND DECOUPLING

The AD676 has three power supply input pins. $\mathrm{V}_{\mathrm{CC}}$ and $\mathrm{V}_{\mathrm{EE}}$ provide the supply voltages to operate the analog portions of the AD676 including the ADC and sample-hold amplifier (SHA).
$\mathrm{V}_{\mathrm{DD}}$ provides the supply voltage which operates the digital portions of the AD676 including the data output buffers and the autocalibration controller.
As with most high performance linear circuits, changes in the power supplies can produce undesired changes in the performance of the circuit. Optimally, well regulated power supplies with less than $1 \%$ ripple should be selected. The ac output impedance of a power supply is a complex function of frequency, and in general will increase with frequency. In other words, high frequency switching such as that encountered with digital circuitry requires fast transient currents which most power supplies cannot adequately provide. This results in voltage spikes on the supplies. If these spikes exceed the $\pm 5 \%$ tolerance of the $\pm 12 \mathrm{~V}$ supplies or the $\pm 10 \%$ limits of the +5 V supply, ADC performance will degrade. Additionally, spikes at frequencies higher than 100 kHz will also degrade performance. To compensate for the finite ac output impedance of the supplies, it is necessary to store "reserves" of charge in bypass capacitors. These capacitors can effectively lower the ac impedance presented to the AD676 power inputs which in turn will significantly reduce the magnitude of the voltage spikes. For
bypassing to be effective, certain guidelines should be followed. Decoupling capacitors, typically $0.1 \mu \mathrm{~F}$, should be placed as closely as possible to each power supply pin of the AD676. It is essential that these capacitors be placed physically close to the IC to minimize the inductance of the PCB trace between the capacitor and the supply pin. The logic supply ( $\mathrm{V}_{\mathrm{DD}}$ ) should be decoupled to digital common and the analog supplies ( $\mathrm{V}_{\mathrm{CC}}$ and $\mathrm{V}_{\mathrm{EE}}$ ) to analog common. The reference input is also considered as a power supply pin in this regard and the same decoupling procedures apply. These points are displayed in Figure 4.


Figure 4. Grounding and Decoupling the AD676
Additionally, it is beneficial to have large capacitors ( $>47 \mu \mathrm{~F}$ ) located at the point where the power connects to the PCB with $10 \mu \mathrm{~F}$ capacitors located in the vicinity of the ADC to further reduce low frequency ripple. In systems that will be subjected to particularly harsh environmental noise, additional decoupling may be necessary. RC-filtering on each power supply combined with dedicated voltage regulation can substantially decrease power supply ripple effects (this is further detailed in Figure 7).

## BOARD LAYOUT

Designing with high resolution data converters requires careful attention to board layout. Trace impedance is a significant issue. A 1.22 mA current through a $0.5 \Omega$ trace will develop a voltage drop of 0.6 mV , which is 4 LSBs at the 16 -bit level for a 10 V full-scale span. In addition to ground drops, inductive and capacitive coupling need to be considered, especially when high accuracy analog signals share the same board with digital signals.
Analog and digital signals should not share a common return path. Each signal should have an appropriate analog or digital return routed close to it. Using this approach, signal loops enclose a small area, minimizing the inductive coupling of noise. Wide PC tracks, large gauge wire, and ground planes are highly recommended to provide low impedance signal paths. Separate analog and digital ground planes are also desirable, with a single interconnection point at the AD676 to minimize interference between analog and digital circuitry. Analog signals should be routed as far as possible from digital signals and should cross them, if at all, only at right angles. A solid analog ground plane around the AD676 will isolate it from large switching ground currents. For these reasons, the use of wire wrap circuit construction will not provide adequate performance; careful printed circuit board construction is preferred.

## GROUNDING

The AD676 has three grounding pins, designated ANALOG GROUND (AGND), DIGITAL GROUND (DGND) and ANALOG GROUND SENSE (AGND SENSE). The analog ground pin is the "high quality" ground reference point for the device, and should be connected to the analog common point in the system.
AGND SENSE is intended to be connected to the input signal ground reference point. This allows for slight differences in level between the analog ground point in the system and the input signal ground point. However no more than 100 mV is recommended between the AGND and the AGND SENSE pins for specified performance.
Using AGND SENSE to remotely sense the ground potential of the signal source can be useful if the signal has to be carried some distance to the A/D converter. Since all IC ground currents have to return to the power supply and no ground leads are free from resistance and inductance, there are always some voltage differences from one ground point in a system to another.
Over distance this voltage difference can easily amount to several LSBs (in a 10 V input span, 16 -bit system each LSB is about 0.15 mV ). This would directly corrupt the A/D input signal if the $A / D$ measures its input with respect to power ground (AGND) as shown in Figure 5a. To solve this problem the AD676 offers an AGND SENSE pin. Figure 5b shows how the AGND SENSE can be used to eliminate the problem in Figure 5 a . Figure 5 b also shows how the signal wires should be shielded in a noisy environment to avoid capacitive coupling. If inductive (magnetic) coupling is expected to be dominant such as where motors are present, twisted-pair wires should be used instead.
The digital ground pin is the reference point for all of the digital signals that operate the AD676. This pin should be connected to the digital common point in the system. As Figure 4 illustrated, the analog and digital grounds should be connected together at one point in the system, preferably at the AD676.


Figure 5a. Input to the $A / D$ Is Corrupted by IR Drop in Ground Leads: $V_{I N}=V_{S}+\Delta V$.


Figure 5b. AGND SENSE Eliminates the Problem in Figure 5a.

## VOLTAGE REFERENCE

The AD676 requires the use of an external voltage reference. The input voltage range is determined by the value of the reference voltage; in general, a reference voltage of n volts allows an input range of $\pm \mathrm{n}$ volts. The AD676 is specified for both 10 V and 5.0 V references. A 10 V reference will typically require support circuitry operated from $\pm 15 \mathrm{~V}$ supplies; a 5.0 V reference may be used with $\pm 12 \mathrm{~V}$ supplies. Signal-to-noise performance is increased proportionately with input signal range. In the presence of a fixed amount of system noise, increasing the LSB size (which results from increasing the reference voltage) will increase the effective $\mathrm{S} /(\mathrm{N}+\mathrm{D})$ performance. Figure 12 illustrates $\mathrm{S} /(\mathrm{N}+\mathrm{D})$ as a function of reference voltage. In contrast, INL will be optimal at lower reference voltage values (such as 5 V ) due to capacitor nonlinearity at higher voltage values.
During a conversion, the switched capacitor array of the AD676 presents a dynamically changing current load at the voltage reference as the successive-approximation algorithm cycles through various choices of capacitor weighting. (See the following section "Analog Input" for a detailed discussion of the $\mathrm{V}_{\text {REF }}$ input characteristics.) The output impedance of the reference circuitry must be low so that the output voltage will remain sufficiently constant as the current drive changes. In some applications, this may require that the output of the voltage reference be buffered by an amplifier with low impedance at relatively high frequencies. In choosing a voltage reference, consideration should be made for selecting one with low noise. A capacitor connected between REF IN and AGND will reduce the demands on the reference by decreasing the magnitude of high frequency components required to be sourced by the reference.
Figures 6 and 7 represent typical design approaches.


Figure 6.
Figure 6 shows a voltage reference circuit featuring the 5 V output AD586. The AD586 is a low cost reference which utilizes a buried Zener architecture to provide low noise and drift. Over the $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ range, the AD 586 L grade exhibits less than 2.25 mV output change from its initial value at $+25^{\circ} \mathrm{C}$. A noisereduction capacitor, $\mathrm{C}_{\mathrm{N}}$, reduces the broadband noise of the AD586 output, thereby optimizing the overall performance of the AD676. It is recommended that a $10 \mu \mathrm{~F}$ to $47 \mu \mathrm{~F}$ high quality tantalum capacitor be tied between the $\mathrm{V}_{\text {REF }}$ input of the AD676 and ground to minimize the impedance on the reference.


Figure 7.
Using the AD676 with $\pm 10 \mathrm{~V}$ input range $\left(\mathrm{V}_{\mathrm{REF}}=10 \mathrm{~V}\right)$ typically requires $\pm 15 \mathrm{~V}$ supplies to drive op amps and the voltage reference. If $\pm 12 \mathrm{~V}$ is not available in the system, regulators such as 78 L 12 and 79 L 12 can be used to provide power for the AD676. This is also the recommended approach (for any input range) when the ADC system is subjected to harsh environments such as where the power supplies are noisy and where voltage spikes are present. Figure 7 shows an example of such a system based upon the 10 V AD587 reference, which provides a $300 \mu \mathrm{~V}$ LSB. Circuitry for additional protection against power supply disturbances has been shown. A $100 \mu \mathrm{~F}$ capacitor at each regulator prevents very large voltage spikes from entering the regulators. Any power line noise which the regulators cannot eliminate will be further filtered by an RC filter ( $10 \Omega / 10 \mu \mathrm{~F}$ ) having a -3 dB point at 1.6 kHz . For best results the regulators should be within a few centimeters of the AD676.

## ANALOG INPUT

As previously discussed, the analog input voltage range for the AD676 is $\pm \mathrm{V}_{\mathrm{REF}}$. For purposes of ground drop and common mode rejection, the $\mathrm{V}_{\text {IN }}$ and $\mathrm{V}_{\text {REF }}$ inputs each have their own ground. $\mathrm{V}_{\mathrm{REF}}$ is referred to the local analog system ground (AGND), and $\mathrm{V}_{\mathrm{IN}}$ is referred to the analog ground sense pin (AGND SENSE) which allows a remote ground sense for the input signal.
The AD676 analog inputs ( $\mathrm{V}_{\mathrm{IN}}, \mathrm{V}_{\text {REF }}$ and AGND SENSE) exhibit dynamic characteristics. When a conversion cycle begins, each analog input is connected to an internal, discharged 50 pF capacitor which then charges to the voltage present at the corresponding pin. The capacitor is disconnected when SAMPLE is taken LOW, and the stored charge is used in the subsequent conversion. In order to limit the demands placed on the external source by this high initial charging current, an internal buffer amplifier is employed between the input and this capacitance for a few hundred nanoseconds. During this time the input pin exhibits typically $20 \mathrm{k} \Omega$ input resistance, 10 pF input capacitance and $\pm 40 \mu \mathrm{~A}$ bias current. Next, the input is switched
directly to the now precharged capacitor and allowed to fully settle. During this time the input sees only a 50 pF capacitor. Once the sample is taken, the input is internally floated so that the external input source sees a very high input resistance and a parasitic input capacitance of typically only 2 pF . As a result, the only dominant input characteristic which must be considered is the high current steps which occur when the internal buffers are switched in and out.
In most cases, these characteristics require the use of an external op amp to drive the input of the AD676. Care should be taken with op amp selection; even with modest loading conditions, most available op amps do not meet the low distortion requirements necessary to match the performance capabilities of the AD676. Figure 8 represents a circuit, based upon the AD845, recommended for low noise, low distortion ac applications.
For applications optimized more for low bias and low offset than speed or bandwidth, the AD845 of Figure 8 may be replaced by the OP-27.


Figure 8.

## AC PERFORMANCE

AC parameters, which include $\mathrm{S} /(\mathrm{N}+\mathrm{D})$, THD, etc., reflect the AD676's effect on the spectral content of the analog input signal. Figures 12 through 16 provide information on the AD676's ac performance under a variety of conditions.
As a general rule, averaging the results from several conversions reduces the effects of noise, and therefore improves such parameters as $\mathrm{S} /(\mathrm{N}+\mathrm{D})$. AD676 performance may be optimized by operating the device at its maximum sample rate of 100 kSPS and digitally filtering the resulting bit stream to the desired signal bandwidth. This succeeds in distributing noise over a wider frequency range, thus reducing the noise density in the frequency band of interest. This subject is discussed in the following section.

## OVERSAMPLING AND NOISE FILTERING

The Nyquist rate for a converter is defined as one-half its sampling rate. This is established by the Nyquist theorem, which requires that a signal be sampled at a rate corresponding to at least twice its highest frequency component of interest in order to preserve the informational content. Oversampling is a conversion technique in which the sampling frequency is more than twice the frequency bandwidth of interest. In audio applications, the AD676 can operate at a $2 \times \mathrm{F}_{\mathrm{S}}$ oversampling rate, where $\mathrm{F}_{\mathrm{S}}$ $=48 \mathrm{kHz}$.

In quantized systems, the informational content of the analog input is represented in the frequency spectrum from dc to the Nyquist rate of the converter. Within this same spectrum are higher frequency noise and signal components. Antialias, or low pass, filters are used at the input to the ADC to reduce these noise and signal components so that their aliased components do not corrupt the baseband spectrum. However, wideband noise contributed by the AD676 will not be reduced by the antialias filter. The AD676 quantization noise is evenly distributed from dc to the Nyquist rate, and this fact can be used to minimize its overall affect.
The AD676 quantization noise effects can be reduced by oversampling-sampling at a rate higher than that defined by the Nyquist theorem. This spreads the noise energy over a bandwidth wider than the frequency band of interest. By judicious selection of a digital decimation filter, noise frequencies outside the bandwidth of interest may be eliminated.
The process of analog to digital conversion inherently produces noise, known as quantization noise. The magnitude of this noise is a function of the resolution of the converter, and manifests itself as a limit to the theoretical signal-to-noise ratio achievable. This limit is described by $\mathrm{S} /(\mathrm{N}+\mathrm{D})=(6.02 \mathrm{n}+1.76+10 \log$ $\left.\mathrm{F}_{\mathrm{S}} / 2 \mathrm{~F}_{\mathrm{A}}\right) \mathrm{dB}$, where n is the resolution of the converter in bits, $\mathrm{F}_{\mathrm{S}}$ is the sampling frequency, and Fa is the signal bandwidth of interest. For audio bandwidth applications, the AD676 is capable of operating at a $2 \times$ oversample rate ( 96 kSPS ), which typically produces an improvement in $\mathrm{S} /(\mathrm{N}+\mathrm{D})$ of 3 dB compared with operating at the Nyquist conversion rate of 48 kSPS. Oversampling has another advantage as well; the demands on the antialias filter are lessened. In summary, system performance is optimized by running the AD676 at or near its maximum sampling rate of 100 kHz and digitally filtering the resulting spectrum to eliminate undesired frequencies.

## DC CODE UNCERTAINTY

Ideally, a fixed dc input should result in the same output code for repetitive conversions. However, as a consequence of system noise and circuit noise, for a given input voltage there is a range of output codes which may occur. Figure 9 is a histogram of the codes resulting from 1000 conversions of a typical input voltage by the AD676 used with a 10 V reference.


Figure 9. Distribution of Codes from 1000 Conversions, Relative to the Correct Code.

The standard deviation of this distribution is approximately 0.5 LSBs. If less uncertainty is desired, averaging multiple conversions will narrow this distribution by the inverse of the square root of the number of samples; i.e., the average of 4 conversions would have a standard deviation of 0.25 LSBs.

## MICROPROCESSOR INTERFACE

The AD676 is ideally suited for use in both traditional dc measurement applications supporting a microprocessor, and in ac signal processing applications interfacing to a digital signal processor. The AD676 is designed to interface with a 16 -bit data bus, providing all output data bits in a single read cycle. A variety of external buffers, such as 74 HC 541 , can be used with the AD676 to provide 3-state outputs, high driving capability, and to prevent bus noise from coupling into the ADC. The following sections illustrate the use of the AD676 with a representative digital signal processor and microprocessor. These circuits provide general interface practices which are applicable to other processor choices.

## ADSP-2101

Figure 10a shows the AD676 interfaced to the ADSP-2101 DSP processor. The AD676 buffers are mapped in the ADSP-2101's memory space, requiring one wait state when using a 12.5 MHz processor clock.
The falling edge of BUSY interrupts the processor, indicating that new data is ready. The ADSP-2101 automatically jumps to the appropriate service routine with minimal overhead. The interrupt routine then instructs the processor to read the new data using a memory read instruction.


Figure 10a.

Figure 10b shows circuitry which would be included by a typical address decoder for the output buffers. In this case, a data memory access to any address in the range 3000 H to 37 FFH will result in the output buffers being enabled.
The AD676 CLK and SAMPLE can be generated by dividing down the system clock as described earlier (Figure 3), or if the ADSP-2101 serial port clocks are not being used, they can be programmed to generate CLK and SAMPLE.


Figure $10 b$.

## 80286

The 80286 16-bit microprocessor can be interfaced to a buffered AD676 without any generation of wait states. As seen in Figure 11, BUSY can be used both to control the AD676 clock and to alert the processor when new data is ready. In the system shown, the 80286 should be configured in an edge triggered, direct interrupt mode (integrated controller provides the interrupt vector). Since the 80286 does not latch interrupt signals, the interrupt needs to be internally acknowledged before BUSY goes HIGH again during the next AD676 conversion (BUSY = 0 ). Depending on whether the AD676 buffers are mapped into memory or I/O space, the interrupt service routine will read the data by using either the MOV or the IN instruction. To be able to read all the 16 bits at once, and thereby increase the 80286's efficiency, the buffers should be located at an even address.


Figure 11.

## AD676 - Typical Dynamic Performance



Figure 12. $S /(N+D)$ and $T H D$ vs. $V_{\text {REF }}$


Figure 13. $\mathrm{S} /(\mathrm{N}+\mathrm{D})$ and THD vs. Input Amplitude


Figure 15. IMD Plot for $f_{I N}=1008 \mathrm{~Hz}(f a), 1055 \mathrm{~Hz}(f b)$ at 96 kSPS


Figure 16. AC Power Supply Rejection ( $f_{I_{N}}=1.06 \mathrm{kHz}$ )
$f_{\text {SAMPLE }}=96 \mathrm{kSPS}, V_{\text {RIPPLE }}=0.13 \mathrm{Vp-p}$

## FEATURES

Autocalibrating
On-Chip Sample-Hold Function
Serial Output
16 Bits No Missing Codes
$\pm 1$ LSB INL
-99 dB THD
$92 \mathrm{~dB} \mathbf{S} /(\mathrm{N}+\mathrm{D})$
1 MHz Full Power Bandwidth

## PRODUCT DESCRIPTION

The AD677 is a multipurpose 16-bit serial output analog-todigital converter which utilizes a switched-capacitor/charge redistribution architecture to achieve a 100 kSPS conversion rate ( $10 \mu \mathrm{~s}$ total conversion time). Overall performance is optimized by digitally correcting internal nonlinearities through on-chip autocalibration.
The AD677 circuitry is segmented onto two monolithic chips a digital control chip fabricated on Analog Devices DSP CMOS process and an analog ADC chip fabricated on our BiMOS II process. Both chips are contained in a single package.
The AD677 is specified for ac (or "dynamic") parameters such as $\mathrm{S} /(\mathrm{N}+\mathrm{D})$ Ratio, THD and IMD which are important in signal processing applications. In addition, dc parameters are specified which are important in measurement applications.
The AD677 operates from +5 V and $\pm 12 \mathrm{~V}$ supplies and typically consumes 450 mW using a 10 V reference ( 360 mW with 5 V reference) during conversion. The digital supply ( $\mathrm{V}_{\mathrm{DD}}$ ) is separated from the analog supplies $\left(\mathrm{V}_{\mathrm{CC}}, \mathrm{V}_{\mathrm{EE}}\right)$ for reduced digital crosstalk. An analog ground sense is provided to remotely sense the ground potential of the signal source. This can be useful if the signal has to be carried some distance to the A/D converter. Separate analog and digital grounds are also provided.
The AD677 is available in a 16 -pin narrow plastic DIP, 16-pin narrow side-brazed ceramic package, or 28 -lead SOIC. A parallel output version, the AD676, is available in a 28 -pin ceramic or plastic DIP. All models operate over a commercial temperature range of $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ or an industrial range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.

FUNCTIONAL BLOCK DIAGRAM


## PRODUCT HIGHLIGHTS

1. Autocalibration provides excellent dc performance while eliminating the need for user adjustments or additional external circuitry.
2. $\pm 5 \mathrm{~V}$ to $\pm 10 \mathrm{~V}$ input range ( $\pm \mathrm{V}_{\mathrm{REF}}$ ).
3. Available in 16-pin $0.3^{\prime \prime}$ skinny DIP or 28 -lead SOIC.
4. Easy serial interface to standard ADI DSPs.
5. TTL compatible inputs/outputs.
6. Excellent ac performance: -99 dB THD, $92 \mathrm{~dB} \mathrm{~S} /(\mathrm{N}+\mathrm{D})$, peak spurious -101 dB .
7. Industry leading dc performance: 1.0 LSB INL, $\pm 1$ LSB full scale and offset.

## AD671 - SPECIFICATIONS

AC SPECIFICATIONS $\mathrm{T}_{\mathrm{mIN}}$ to $\left.\mathrm{T}_{\text {mxx }}, \mathrm{V}_{\mathrm{Cc}}=+12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{EE}}=-12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{DO}}=+5 \mathrm{~V} \pm 10 \%\right)^{1}$

| Parameter | AD677J/A |  |  | AD677K/B |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max |  |
| Total Harmonic Distortion (THD) ${ }^{2}$ <br> @ $83 \mathrm{kSPS}, \mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ <br> @ $100 \mathrm{kSPS},+25^{\circ} \mathrm{C}$ <br> @ $100 \mathrm{kSPS}, \mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ <br> Signal-to-Noise and Distortion Ratio $(\mathrm{S} /(\mathrm{N}+\mathrm{D}))^{2,3}$ <br> @ $83 \mathrm{kSPS}, \mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ <br> @ 100 kSPS, $+25^{\circ} \mathrm{C}$ <br> @ $100 \mathrm{kSPS}, \mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ <br> Peak Spurious or Peak Harmonic Component <br> Intermodulation Distortion (IMD) ${ }^{4}$ <br> 2nd Order Products <br> 3rd Order Products <br> Full Power Bandwidth <br> Noise |  |  |  |  |  |  |  |
|  |  | -97 | -92 |  | -99 | -95 | dB |
|  |  | -97 | -92 |  | -99 | -95 | dB |
|  |  | -93 |  |  | -95 |  | dB |
|  |  |  |  |  |  |  |  |
|  | 89 | 91 |  | 90 | 92 |  | dB |
|  | 89 | 91 |  | 90 | 92 |  | dB |
|  |  | 89 |  |  | 90 |  | dB |
|  |  | -101 |  |  | -101 |  | dB |
|  |  |  |  |  |  |  |  |
|  |  | -102 |  |  | -102 |  | dB |
|  |  | -98 |  |  | -98 |  | dB |
|  |  | 1 |  |  | 1 |  | MHz |
|  |  | 160 |  |  | 160 |  | $\mu \mathrm{V}$ rms |

## DIGITAL SPECIFICATIONS (for all grades $T_{M I N}$ to $T_{M A X}, V_{C C}=+12 V \pm 5 \%, V_{E E}=-12 V \pm 5 \%, V_{D D}=+5 V \pm 10 \%$ )



## NOTES

${ }^{1} \mathrm{~V}_{\text {REF }}=10.0 \mathrm{~V}$, Conversion Rate $=100 \mathrm{kSPS}, \mathrm{f}_{\mathrm{IN}}=1.0 \mathrm{kHz}, \mathrm{V}_{\mathrm{IN}}=-0.05 \mathrm{~dB}$, Bandwidth $=50 \mathrm{kHz}$ unless otherwise indicated. All measurements referred
to a $0 \mathrm{~dB}(20 \mathrm{~V}-\mathrm{p})$ input signal. Values are post-calibration.
${ }^{2}$ For other input amplitudes, refer to Figure 12.
${ }^{3}$ For dynamic performance with different voltage reference values see Figure 11.
${ }^{4} \mathrm{fa}=1008 \mathrm{~Hz}, \mathrm{fb}=1055 \mathrm{~Hz}$. See Definition of Specifications section and Figure 16.
Specifications subject to change without notice.

DC SPECIFICATIONS $\left(T_{\text {MIN }} \text { to } \mathrm{T}_{\text {MAX }}, \mathrm{V}_{\mathrm{CC}}=+12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{EE}}=-12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{DD}}=+5 \mathrm{~V} \pm 10 \%\right)^{1}$

| Parameter | AD677J/A |  |  | AD677K/B |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max |  |
| TEMPERATURE RANGE |  |  |  |  |  |  |  |
| J, K Grades | 0 |  | +70 | 0 |  | +70 | ${ }^{\circ} \mathrm{C}$ |
| A, B Grades | -40 |  | +85 | -40 |  | +85 | ${ }^{\circ} \mathrm{C}$ |
| ACCURACY |  |  |  |  |  |  |  |
| Resolution | 16 |  |  | 16 |  |  | Bits |
| Integral Nonlinearity (INL) |  |  |  |  |  |  |  |
| @ $83 \mathrm{kSPS}, \mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |  | $\pm 1$ |  |  | $\pm 1$ | $\pm 1.5$ | LSB |
| @ $100 \mathrm{kSPS},+25^{\circ} \mathrm{C}$ |  | $\pm 1$ |  |  | +1 | $\pm 1.5$ | LSB |
| @ $100 \mathrm{kSPS}, \mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |  | $\pm 2$ |  |  | $\pm 2$ |  | LSB |
| Differential Nonlinearity (DNL)-No Missing Codes |  | 16 |  | 16 |  |  | Bits |
| Bipolar Zero Error ${ }^{2}$ |  | $\pm 2$ | $\pm 4$ |  | $\pm 1$ | $\pm 3$ | LSB |
| Positive, Negative FS Errors ${ }^{2}$ |  |  |  |  |  |  |  |
| @ 83 kSPS |  | $\pm 2$ | $\pm 4$ |  | $\pm 1$ | $\pm 3$ | LSB |
| @ $100 \mathrm{kSPS},+25^{\circ} \mathrm{C}$ |  | $\pm 2$ | $\pm 4$ |  | $\pm 1$ | $\pm 3$ | LSB |
| @ 100 kSPS |  | $\pm 4$ |  |  | $\pm 4$ |  | LSB |
| TEMPERATURE DRIFT ${ }^{3}$ |  |  |  |  |  |  |  |
| Bipolar Zero |  | $\pm 0.5$ |  |  | $\pm 0.5$ |  | LSB |
| Positive Full Scale |  | $\pm 0.5$ |  |  | $\pm 0.5$ |  | LSB |
| Negative Full Scale |  | $\pm 0.5$ |  |  | $\pm 0.5$ |  | LSB |
| VOLTAGE REFERENCE INPUT RANGE ${ }^{4}$ ( $\mathrm{V}_{\text {REF }}$ ) | 5 |  | 10 | 5 |  | 10 | V |
| ANALOG INPUT ${ }^{5}$ |  |  |  |  |  |  |  |
| Input Range ( $\mathrm{V}_{\text {IN }}$ ) |  |  | $\pm \mathrm{V}_{\text {REF }}$ |  |  | $\pm \mathrm{V}_{\text {REF }}$ | V |
| Input Impedance |  | * |  |  | * |  |  |
| Input Settling Time |  | 2 |  |  | 2 |  | $\mu \mathrm{s}$ |
| Input Capacitance During Sample |  |  | 50* |  |  | 50* | pF |
| Aperture Delay |  | 6 |  |  | 6 |  | ns |
| Aperture Jitter |  | 100 |  |  | 100 |  | ps |
| POWER SUPPLIES |  |  |  |  |  |  |  |
| Power Supply Rejection ${ }^{6}$ |  |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{CC}}=+12 \mathrm{~V} \pm 5 \%$ |  | $\pm 0.5$ |  |  | $\pm 0.5$ |  | LSB |
| $\mathrm{V}_{\mathrm{EE}}=-12 \mathrm{~V} \pm 5 \%$ |  | $\pm 0.5$ |  |  | $\pm 0.5$ |  | LSB |
| $\mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V} \pm 10 \%$ |  | $\pm 0.5$ |  |  | $\pm 0.5$ |  | LSB |
| Operating Current |  |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{REF}}=+5 \mathrm{~V}$ |  |  |  |  |  |  |  |
| $\mathrm{I}_{\mathrm{CC}}$ |  | 14.5 | 18 |  | 14.5 | 18 | mA |
| $\mathrm{I}_{\text {EE }}$ |  | 14.5 | 18 |  | 14.5 | 18 | $-m A$ |
| $\mathrm{I}_{\mathrm{DD}}$ |  | 3 | 5 |  | 3 | 5 | mA |
| Power Consumption |  | 360 | 480 |  | 360 | 480 | mW |
| $\mathrm{V}_{\text {REF }}=+10 \mathrm{~V}$ |  |  |  |  |  |  |  |
| $\mathrm{I}_{\mathrm{CC}}$ | $\cdots$ | 18 | 24 |  | 18 | 24 | mA |
| $\mathrm{I}_{\text {EE }}$ |  | 18 | 24 |  | 18 | 24 | $-\mathrm{mA}$ |
| $\mathrm{I}_{\mathrm{DD}}$ |  | 3 | 5 |  | 3 | 5 | mA |
| Power Consumption |  | 450 | 630 |  | 450 | 630 | mW |

## NOTES

${ }^{1} \mathrm{~V}_{\text {REF }}=10.0 \mathrm{~V}$, Conversion Rate $=100 \mathrm{kSPS}$ unless otherwise noted. Values are post-calibration.
${ }^{2}$ Values shown apply to any temperature from $T_{\text {MIN }}$ to $T_{\text {MAX }}$ after calibration at that temperature at nominal supplies.
${ }^{3}$ Values shown are based upon calibration at $+25^{\circ} \mathrm{C}$ with no additional calibration at temperature. Values shown are the typical variation from the value at $+25^{\circ} \mathrm{C}$.
${ }^{4}$ See "APPLICATIONS" section for recommended voltage reference circuit, and Figure 11 for dynamic performance with other reference voltage values.
"See "APPLICATIONS" section for recommended input buffer circuit.
${ }^{6}$ Typical deviation of bipolar zero, -full scale on +full scale from min to max rating.
*For explanation of input characteristics, see "ANALOG INPUT" section.
Specifications subject to change without notice.

TIMING SPECIFICATIONS $\mathrm{T}_{\mathrm{MIN}}$ to $\left.\mathrm{T}_{\mathrm{max}}, \mathrm{V}_{\mathrm{CC}}=+12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{EE}}=-12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{DD}}=+5 \mathrm{~V} \pm 10 \%\right)^{1}$

| Parameter | Symbol | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Conversion Period ${ }^{2,3}$ | ${ }^{\text {c }}$ | 10 |  | 1000 | $\mu \mathrm{S}$ |
| CLK Period ${ }^{4}$ | $\mathrm{t}_{\text {CLK }}$ | 480 |  |  | ns |
| Calibration Time | $\mathrm{t}_{\text {CT }}$ |  |  | 85532 | $\mathrm{t}_{\text {CLK }}$ |
| Sampling Time | $\mathrm{t}_{\text {s }}$ | 2 |  |  | $\mu \mathrm{s}$ |
| Last CLK to SAMPLE Delay ${ }^{5}$ | $\mathrm{t}_{\text {LCS }}$ | 2.1 |  |  | $\mu \mathrm{s}$ |
| SAMPLE Low | $\mathrm{t}_{\text {SL }}$ | 100 |  |  | ns |
| SAMPLE to Busy Delay | $\mathrm{t}_{\text {SB }}$ |  | 30 | 75 | ns |
| 1st CLK Delay | $\mathrm{t}_{\mathrm{FCD}}$ | 50 |  |  | ns |
| CLK Low ${ }^{6}$ | $\mathrm{t}_{\mathrm{CL}}$ | 50 |  |  | ns |
| CLK High ${ }^{6}$ | $\mathrm{t}_{\mathrm{CH}}$ | 50 |  |  | ns |
| CLK to BUSY Delay | ${ }^{\text {t }}$ CB |  | 180 | 300 | ns |
| CLK to SDATA Valid | $\mathrm{t}_{\mathrm{CD}}$ | 50 | 100 | 175 | ns |
| CLK to SCLK High | $\mathrm{t}_{\mathrm{CSH}}$ | 100 | 180 | 300 | ns |
| SCLK Low | $\mathrm{t}_{\text {SCL }}$ | 50 | 80 |  | ns |
| SDATA to SCLK High | $\mathrm{t}_{\text {DSH }}$ | 50 | 80 |  | ns |
| CAL High Time | $\mathrm{t}_{\text {CaLh }}$ | 50 |  |  | ns |
| CAL to BUSY Delay | $t_{\text {CALB }}$ |  | 15 | 50 | ns |

## NOTES

${ }^{1}$ See the "CONVERSION CONTROL" and "AUTOCALIBRATION" sections for detailed explanations of the above timing.
${ }^{2}$ Depends upon external clock frequency; includes acquisition time and conversion time. The maximum conversion period is specified to account for the droop of the internal sample/hold function. Operation at slower rates may degrade performance.
${ }^{3} \mathbf{t}_{\mathrm{C}}=\mathrm{t}_{\mathrm{FCD}}+16 \times \mathrm{t}_{\mathrm{CLK}}+\mathrm{t}_{\mathrm{LCS}}$
${ }^{4} 580 \mathrm{~ns}$ is recommended for optimal accuracy over temperature (not necessary during calibration cycle).
${ }^{5}$ If SAMPLE goes high before the 17th CLK pulse, the device will start sampling approximately 100 ns after the rising edge of the 17 th CLK pulse.
${ }^{6} \mathrm{t}_{\mathrm{CH}}+\mathrm{t}_{\mathrm{CL}}=\mathrm{t}_{\mathrm{CLK}}$ and must be greater than 480 ns .

*SHADED PORTIONS OF INPUT SIGNALS ARE OPTIONAL. FOR BEST PERFORMANCE, WE RECOMMEND THAT THESE SIGNALS BE HELD LOW EXCEPT WHEN EXPLICITY SHOWN HIGH.

Figure 1. Calibration Timing

*SHADED PORTIONS OF INPUT SIGNALS ARE OPTIONAL. FOR BEST PERFORMANCE, WE RECOMMEND THAT THESE SIGNALS BE HELD LOW EXCEPT WHEN EXPLICITY SHOWN HIGH.

Figure 2. General Conversion Timing

ORDERING GUIDE

| Model | Temperature Range | S/(N+D) | Max INL | Package Description | Package <br> Option |
| :--- | :--- | :--- | :--- | :--- | :--- |
| AD677JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 89 dB | Typ Only | Plastic 16-Pin DIP | $\mathrm{N}-16$ |
| AD677KN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 90 dB | $\pm 1.5$ LSB | Plastic 16-Pin DIP | $\mathrm{N}-16$ |
| AD677JD | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 89 dB | Typ Only | Ceramic 16-Pin DIP | $\mathrm{D}-16$ |
| AD677KD | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 90 dB | $\pm 1.5$ LSB | Ceramic 16-Pin DIP | $\mathrm{D}-16$ |
| AD677JR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 89 dB | Typ Only | Plastic 28-Lead SOIC | $\mathrm{R}-28$ |
| AD677KR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 90 dB | $\pm 1.5$ LSB | Plastic 28-Lead SOIC | R-28 |
| AD677AD | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 89 dB | Typ Only | Ceramic 16-Pin DIP | $\mathrm{D}-16$ |
| AD677BD | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 90 dB | $\pm 1.5$ LSB | Ceramic 16-Pin DIP | $\mathrm{D}-16$ |

[^9]
## ABSOLUTE MAXIMUM RATINGS*

|  |  |
| :---: | :---: |
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|  |  |
|  |  |
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|  |  |

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD677 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

PIN DESCRIPTION

| DIP Pin | SOIC Pin | Type | Name | Description |
| :---: | :---: | :---: | :---: | :---: |
| 1 | 1 | SAMPLE | DI | $\mathrm{V}_{\text {IN }}$ Acquisition Control Pin. Active HIGH. During conversion, SAMPLE controls the state of the internal sample-hold amplifier and the falling edge initiates conversion. During calibration, SAMPLE should be held LOW. If HIGH during calibration, diagnostic information will appear on SDATA. |
| 2 | 2 | CLK | DI | Master Clock Input. The AD677 requires 17 clock pulses to execute a conversion. CLK is also used to derive SCLK. |
| 3 | 3 | SDATA | DO | Serial Output Data Controlled by SCLK. |
| 4 | 6,7 | DGND | P | Digital Ground. |
| 5 | 8 | $\mathrm{V}_{\mathrm{Cc}}$ | P | +12 V Analog Supply Voltage. |
| 8 | 12 | AGND | P | Analog Ground. |
| 9 | 15 | AGND SENSE | AI | Analog Ground Sense. |
| 10 | 16 | $\mathrm{V}_{\text {IN }}$ | AI | Analog Input Voltage. |
| 11 | 17 | $\mathrm{V}_{\text {REF }}$ | Al | External Voltage Reference Input. |
| 12 | 21 | $\mathrm{V}_{\text {EE }}$ | P | -12 V Analog Supply Voltage. |
| 13 | 22, 23 | $V_{\text {DD }}$ | P | +5 V Logic Supply Voltage. |
| 14 | 26 | SCLK | DO | Clock Output for Data Read, derived from CLK. |
| 15 | 27 | BUSY | DO | Status Line for Converter. Active HIGH, indicating a conversion or calibration in progress. |
| 16 | 28 | CAL | DI | Calibration Control Pin. |
| 6,7 | $\begin{aligned} & 4,5,9,10,11, \\ & 13,14,18,19, \\ & 20,24,25 \end{aligned}$ | NC | - | No Connection. No connections should be made to these pins. |

Type: $\quad \mathbf{A I}=$ Analog Input
DI $=$ Digital Input
DO = Digital Output
P = Power


SOIC Pinout

# Definition of Specifications-AD671 

## NYQUIST FREQUENCY

An implication of the Nyquist sampling theorem, the "Nyquist frequency" of a converter is that input frequency which is one half the sampling frequency of the converter.

## TOTAL HARMONIC DISTORTION

Total harmonic distortion (THD) is the ratio of the rms sum of the harmonic components to the rms value of a full-scale input signal and is expressed in percent (\%) or decibels (dB). For input signals or harmonics that are above the Nyquist frequency, the aliased components are used.

## SIGNAL-TO-NOISE PLUS DISTORTION RATIO

Signal-to-noise plus distortion is defined to be the ratio of the rms value of the measured input signal to the rms sum of all other spectral components below the Nyquist frequency, including harmonics but excluding dc.

## +/- FULL-SCALE ERROR

The last + transition (from 011 . . 10 to 011 . . 11) should occur for an analog voltage 1.5 LSB below the nominal full scale ( 4.99977 volts for a $\pm 5 \mathrm{~V}$ range). The full-scale error is the deviation of the actual level of the last transition from the ideal level.

## BIPOLAR ZERO ERROR

Bipolar zero error is the difference between the ideal midscale input voltage ( 0 V ) and the actual voltage producing the midscale output code.

## DIFFERENTIAL NONLINEARITY (DNL)

In an ideal ADC, code transitions are one LSB apart. Differential nonlinearity is the maximum deviation from this ideal value. It is often specified in terms of resolution for which no missing codes are guaranteed.

## INTEGRAL NONLINEARITY (INL)

The ideal transfer function for an ADC is a straight line bisecting the center of each code drawn between "zero" and "full scale." The point used as "zero" occurs $1 / 2$ LSB before the most negative code transition. "Full scale" is defined as a level 1:5 LSB beyond the most positive code transition. Integral nonlinearity is the worst-case deviation of a code center average from the straight line.

## BANDWIDTH

The full-power bandwidth is that input frequency at which the amplitude of the reconstructed fundamental is reduced by 3 dB for a full-scale input.

## INTERMODULATION DISTORTION (IMD)

With inputs consisting of sine waves at two frequencies, fa and fb , any device with nonlinearities will create distortion products, of order ( $\mathbf{m}+\mathbf{n}$ ), at sum and difference frequencies of $\mathbf{m f a} \pm$ nfb , where $\mathrm{m}, \mathrm{n}=0,1,2,3 \ldots$ Intermodulation terms are those for which $m$ or $n$ is not equal to zero. For example, the second order terms are ( $\mathrm{fa}+\mathrm{fb}$ ) and ( $\mathrm{fa}-\mathrm{fb}$ ), and the third order terms are ( $2 \mathrm{fa}+\mathrm{fb}$ ), ( $2 \mathrm{fa}-\mathrm{fb}$ ), ( $\mathrm{fa}+2 \mathrm{fb}$ ) and ( $\mathrm{fa}-$ 2 fb ). The IMD products are expressed as the decibel ratio of the rms sum of the measured input signals to the rms sum of the distortion terms. The two signals applied to the converter are of equal amplitude, and the peak value of their sum is -0.5 dB from full scale. The IMD products are normalized to a 0 dB input signal.

## APERTURE DELAY

Aperture delay is the time required after SAMPLE pin is taken LOW for the internal sample-hold of the AD677 to open, thus holding the value of $\mathrm{V}_{\mathrm{IN}}$.

## APERTURE JITTER

Aperture jitter is the variation in the aperture delay from sample to sample.

## POWER SUPPLY REJECTION

DC variations in the power supply voltage will affect the overall transfer function of the ADC, resulting in zero error and fullscale error changes. Power supply rejection is the maximum change in either the bipolar zero error or full-scale error value. Additionally, there is another power supply variation to consider. AC ripple on the power supplies can couple noise into the ADC, resulting in degradation of dynamic performance. This is displayed in Figure 15.

## INPUT SETTLING TIME

Settling time is a function of the SHA's ability to track fast slewing signals. This is specified as the maximum time required in track mode after a full-scale step input to guarantee rated conversion accuracy.

## NOISE/DC CODE UNCERTAINTY

Ideally, a fixed dc input should result in the same output code for repetitive conversions. However, as a consequence of unavoidable circuit noise within the wideband circuits in the ADC, there is a range of output codes which may occur for a given input voltage. If you apply a dc signal to the ADC and record a large number of conversions, the result will be a distribution of codes. If you fit a Gaussian probability distribution to the histogram, the standard deviation is approximately equivalent to the rms input noise of the ADC.

## FUNCTIONAL DESCRIPTION

The AD677 is a multipurpose 16-bit analog-to-digital converter and includes circuitry which performs an input sample/hold function, ground sense, and autocalibration. These functions are segmented onto two monolithic chips-an analog signal processor and a digital controller. Both chips are contained within the AD677 package.
The AD677 employs a successive-approximation technique to determine the value of the analog input voltage. However, instead of the traditional laser-trimmed resistor-ladder approach, this device uses a capacitor-array, charge redistribution technique. Binary-weighted capacitors subdivide the input sample to perform the actual analog-to-digital conversion. The capacitor array eliminates variation in the linearity of the device due to temperature-induced mismatches of resistor values. Since a capacitor array is used to perform the data conversions, the sample/hold function is included without the need for additional external circuitry.
Initial errors in capacitor matching are eliminated by an autocalibration circuit within the AD677. This circuit employs an on-chip microcontroller and a calibration DAC to measure and compensate capacitor mismatch errors. As each error is determined, its value is stored in on-chip memory (RAM). Subsequent conversions use these RAM values to improve conversion accuracy. The autocalibration routine may be invoked at any time. Autocalibration insures high performance while eliminating the need for any user adjustments and is described in detail below.
The microcontroller controls all of the various functions within the AD677. These include the actual successive approximation algorithm, the autocalibration routine, the sample/hold operation, and the internal output data latch.

## AUTOCALIBRATION

The AD677 achieves rated performance without the need for user trims or adjustments. This is accomplished through the use of on-chip autocalibration.
In the autocalibration sequence, sample/hold offset is nulled by internally connecting the input circuit to the ground sense circuit. The resulting offset voltage is measured and stored in RAM for later use. Next, the capacitor representing the most significant bit (MSB) is charged to the reference voltage. This charge is then transferred to a capacitor of equal size (composed of the sum of the remaining lower weight bits). The voltage that results represents the amount of capacitor mismatch. A calibration digital-to-analog converter (DAC) adds an appropriate value of error correction voltage to cancel this mismatch. This correction factor is also stored in RAM. This process is repeated for each of the eight remaining capacitors representing the top nine bits. The accumulated values in RAM are then used during subsequent conversions to adjust conversion results accordingly.
As shown in Figure 1, when CAL is taken HIGH the AD677 internal circuitry is reset, the BUSY pin is driven HIGH, and the ADC prepares for calibration. This is an asynchronous hardware reset and will interrupt any conversion or calibration currently in progress. Actual calibration begins when CAL is taken LOW and completes in 85,532 clock cycles, indicated by BUSY going LOW. During calibration, it is preferable for SAMPLE to
be held LOW. If SAMPLE is HIGH, diagnostic data will appear on SDATA. This data is of no value to the user.
In most applications, it is sufficient to calibrate the AD677 only upon power-up, in which case care should be taken that the power supplies and voltage reference have stabilized first. If calibration is not performed, the AD677 may come up in an unknown state, or performance could degrade to as low as 10 bits.

## CONVERSION CONTROL

The AD677 is controlled by two signals: SAMPLE and CLK, as shown in Figure 2. It is assumed that the part has been calibrated and the digital I/O pins have the levels shown at the start of the timing diagram.
A conversion consists of an input acquisition followed by 17 clock pulses which execute the 16-bit internal successive approximation routine. The analog input is acquired by taking the SAMPLE line HIGH for a minimum sampling time of $\mathrm{t}_{\mathrm{s}}$. The actual sample taken is the voltage present on $\mathrm{V}_{\text {IN }}$ one aperture delay after the SAMPLE line is brought LOW, assuming the previous conversion has completed (signified by BUSY going LOW). Care should be taken to ensure that this negative edge is well defined and jitter free in ac applications to reduce the uncertainty (noise) in signal acquisition. With SAMPLE going LOW, the AD677 commits itself to the conversion-the input at $\mathrm{V}_{\mathrm{IN}}$ is disconnected from the internal capacitor array, BUSY goes HIGH, and the SAMPLE input will be ignored until the conversion is completed (when BUSY goes LOW). SAMPLE must be held LOW for a minimum period of time $t_{\text {SL }}$. A period of time $\mathrm{t}_{\mathrm{FCD}}$ after bringing SAMPLE LOW, the 17 CLK cycles are applied; CLK pulses that start before this period of time are ignored. BUSY goes HIGH $\mathrm{t}_{\mathrm{SB}}$ after SAMPLE goes LOW, signifying that a conversion is in process, and remains HIGH until the conversion is completed. As indicated in Figure 2, the twos complement output data is presented MSB first. This data may be captured with the rising edge of SCLK or the falling edge of CLK, beginning with pulse \#2. The AD677 will ignore CLK after BUSY has gone LOW and SDATA or SCLK will not change until a new sample is acquired.

## CONTINUOUS CONVERSION

For maximum throughput rate, the AD677 can be operated in a continuous convert mode. This is accomplished by utilizing the fact that SAMPLE will no longer be ignored after BUSY goes LOW, so an acquisition may be initiated even during the HIGH time of the 17 th CLK pulse for maximum throughput rate while enabling full settling of the sample/hold circuitry. If SAMPLE is already HIGH during the rising edge of the 17th CLK, then an acquisition is immediately initiated approximately 100 ns after the rising edge of the 17 th clock pulse.
Care must be taken to adhere to the minimum/maximum timing requirements in order to preserve conversion accuracy.

## GENERAL CONVERSION GUIDELINES

During signal acquisition and conversion, care should be taken with the logic inputs to avoid digital feedthrough noise. It is possible to run CLK continuously, even during the sample period. However, CLK edges during the sampling period, and especially when SAMPLE goes LOW, may inject noise into the sampling process. The AD677 is tested with no CLK cycles during the sampling period. The BUSY signal can be used to prevent the clock from running during acquisition, as illustrated
in Figure 3. In this circuit BUSY is used to reset the circuitry which divides the system clock down to provide the AD677 CLK. This serves to interrupt the clock until after the input signal has been acquired, which has occurred when BUSY goes HIGH. When the conversion is completed and BUSY goes LOW, the circuit in Figure 3 truncates the 17th CLK pulse width which is tolerable because only its rising edge is critical.


Figure 3.
Figure 3 also illustrates the use of a counter ( 74 HC 393 ) to derive the AD677 SAMPLE command from the system clock when a continuous convert mode is desirable. Pin 9 (2QC) provides a 96 kHz sample rate for the AD677 when used with a 12.288 MHz system clock. Alternately, Pin 8 (2QD) could be used for a 48 kHz rate.
If a continuous clock is used, then the user must avoid CLK edges at the instant of disconnecting $V_{\text {IN }}$ which occurs at the falling edge of SAMPLE (see $\mathrm{t}_{\mathrm{FCD}}$ specification). The duty cycle of CLK may vary, but both the HIGH $\left(\mathrm{t}_{\mathrm{CH}}\right)$ and LOW ( $\mathrm{t}_{\mathrm{CL}}$ ) phases must conform to those shown in the timing specifications. The internal comparator makes its decisions on the rising edge of CLK. To avoid a negative edge transition disturbing the comparator's settling, $\mathrm{t}_{\mathrm{CL}}$ should be at least half the value of $\mathrm{t}_{\mathrm{CLK}}$. It is not recommended that the SAMPLE pin change state toward the end of a CLK cycle, in order to avoid transitions disturbing the internal comparator's settling.
During a conversion, internal dc error terms such as comparator voltage offset are sampled, stored on internal capacitors and used to correct for their corresponding errors when needed. Because these voltages are stored on capacitors, they are subject to leakage decay and so require refreshing. For this reason there is a maximum conversion time $\mathrm{t}_{\mathrm{C}}(1000 \mu \mathrm{~s})$. From the time SAMPLE goes HIGH to the completion of the 17th CLK pulse, no more than $1000 \mu s$ should elapse for specified performance. However, there is no restriction to the maximum time between individual conversions.
Output coding for the AD677 is twos complement as shown in Table I. The AD677 is designed to limit output coding in the event of out-of-range input.

Table I. Serial Output Coding Format (Twos Complement)

| $\mathbf{V}_{\text {IN }}$ | Output Code |
| :--- | :--- |
| $<$ Full Scale | $011 \ldots 11$ |
| Full Scale | $011 \ldots 11$ |
| Full Scale - 1 LSB | $011 \ldots 10$ |
| Midscale + 1 LSB | $000 \ldots 01$ |
| Midscale | $000 \ldots 00$ |
| Midscale - 1 LSB | $111 \ldots 11$ |
| -Full Scale + 1 LSB | $100 \ldots 01$ |
| -Full Scale | $100 \ldots 00$ |
| - Full Scale | $100 \ldots 00$ |

## POWER SUPPLIES AND DECOUPLING

The AD677 has three power supply input pins. $\mathrm{V}_{\mathrm{CC}}$ and $\mathrm{V}_{\mathrm{EE}}$ provide the supply voltages to operate the analog portions of the AD677 including the capacitor DAC, input buffers and comparator. $\mathrm{V}_{\mathrm{DD}}$ provides the supply voltage which operates the digital portions of the AD677 including the data output buffers and the autocalibration controller.

As with most high performance linear circuits, changes in the power supplies can produce undesired changes in the performance of the circuit. Optimally, well regulated power supplies with less than $1 \%$ ripple should be selected. The ac output impedance of a power supply is a complex function of frequency, and in general will increase with frequency. In other words, high frequency switching such as that encountered with digital circuitry requires fast transient currents which most power supplies cannot adequately provide. This results in voltage spikes on the supplies. If these spikes exceed the $\pm 5 \%$ tolerance of the $\pm 12 \mathrm{~V}$ supplies or the $\pm 10 \%$ limits of the +5 V supply, ADC performance will degrade. Additionally, spikes at frequencies higher than 100 kHz will also degrade performance. To compensate for the finite ac output impedance of the supplies, it is necessary to store "reserves" of charge in bypass capacitors. These capacitors can effectively lower the ac impedance presented to the AD677 power inputs which in turn will significantly reduce the magnitude of the voltage spikes. For bypassing to be effective, certain guidelines should be followed. Decoupling capacitors, typically $0.1 \mu \mathrm{~F}$, should be placed as closely as possible to each power supply pin of the AD677. It is essential that these capacitors be placed physically close to the IC to minimize the inductance of the PCB trace between the capacitor and the supply pin. The logic supply ( $\mathrm{V}_{\mathrm{DD}}$ ) should be decoupled to digital common and the analog supplies ( $\mathrm{V}_{\mathrm{CC}}$ and $\mathrm{V}_{\mathrm{EE}}$ ) to analog common. The reference input is also considered as a power supply pin in this regard and the same decoupling procedures apply. These points are displayed in Figure 4.


Figure 4. Grounding and Decoupling the AD677

Additionally, it is beneficial to have large capacitors ( $>47 \mu \mathrm{~F}$ ) located at the point where the power connects to the PCB with $10 \mu \mathrm{~F}$ capacitors located in the vicinity of the ADC to further reduce low frequency ripple. In systems that will be subjected to particularly harsh environmental noise, additional decoupling may be necessary. RC-filtering on each power supply combined with dedicated voltage regulation can substantially decrease power supply ripple effects (this is further detailed in Figure 7).

## BOARD LAYOUT

Designing with high resolution data converters requires careful attention to board layout. Trace impedance is a significant issue. A 1.22 mA current through a $0.5 \Omega$ trace will develop a voltage drop of 0.6 mV , which is 4 LSBs at the 16 -bit level for a 10 V full-scale span. In addition to ground drops, inductive and capacitive coupling need to be considered, especially when high accuracy analog signals share the same board with digital signals.

Analog and digital signals should not share a common return path. Each signal should have an appropriate analog or digital return routed close to it. Using this approach, signal loops enclose a small area, minimizing the inductive coupling of noise. Wide PC tracks, large gauge wire, and ground planes are highly recommended to provide low impedance signal paths. Separate analog and digital ground planes are also desirable, with a single interconnection point at the AD677 to minimize interference between analog and digital circuitry. Analog signals should be routed as far as possible from digital signals and should cross them, if at all, only at right angles. A solid analog ground plane around the AD677 will isolate it from large switching ground currents. For these reasons; the use of wire wrap circuit construction will not provide adequate performance; careful printed circuit board construction is preferred.

## GROUNDING

The AD677 has three grounding pins, designated ANALOG GROUND (AGND), DIGITAL GROUND (DGND) and ANALOG GROUND SENSE (AGND SENSE). The analog ground pin is the "high quality" ground reference point for the device, and should be connected to the analog common point in the system.

AGND SENSE is intended to be connected to the input signal ground reference point. This allows for slight differences in level between the analog ground point in the system and the input signal ground point. However no more than 100 mV is recommended between the AGND and the AGND SENSE pins for specified performance.

Using AGND SENSE to remotely sense the ground potential of the signal source can be useful if the signal has to be carried some distance to the A/D converter. Since all IC ground currents have to return to the power supply and no ground leads are free from resistance and inductance, there are always some voltage differences from one ground point in a system to another.
Over distance this voltage difference can easily amount to several LSBs (in a 10 V input span, 16 -bit system each LSB is about 0.15 mV ). This would directly corrupt the A/D input signal if the A/D measures its input with respect to power ground (AGND) as shown in Figure 5a. To solve this problem the AD677 offers an AGND SENSE pin. Figure 5b shows how the AGND SENSE can be used to eliminate the problem in Figure 5 a . Figure 5 b also shows how the signal wires should be


Figure 5a. Input to the AVD Is Corrupted by IR Drop in Ground Leads: $V_{I N}=V_{s}+\Delta V$.


Figure 5b. AGND SENSE Eliminates the Problem in Figure 5a.
shielded in a noisy environment to avoid capacitive coupling. If inductive (magnetic) coupling is expected to be dominant such as where motors are present, twisted-pair wires should be used instead.

The digital ground pin is the reference point for all of the digital signals that operate the AD677. This pin should be connected to the digital common point in the system. As Figure 4 illustrated, the analog and digital grounds should be connected together at one point in the system, preferably at the AD677.

## VOLTAGE REFERENCE

The AD677 requires the use of an external voltage reference. The input voltage range is determined by the value of the reference voltage; in general, a reference voltage of $n$ volts allows an input range of $\pm \mathrm{n}$ volts. The AD677 is specified for a voltage reference between +5 V and +10 V . A 10 V reference will typically require support circuitry operated from $\pm 15 \mathrm{~V}$ supplies; a 5.0 V reference may be used with $\pm 12 \mathrm{~V}$ supplies. Signal-tonoise performance is increased proportionately with input signal range (see Figure 12). In the presence of a fixed amount of system noise, increasing the LSB size (which results from increasing the reference voltage) will increase the effective $\mathrm{S} /(\mathrm{N}+\mathrm{D})$ performance. Figure 11 illustrates $\mathrm{S} /(\mathrm{N}+\mathrm{D})$ as a function of reference voltage. In contrast, dc accuracy will be optimal at lower reference voltage values (such as 5 V ) due to capacitor nonlinearity at higher voltage values.
During a conversion, the switched capacitor array of the AD677 presents a dynamically changing current load at the voltage reference as the successive-approximation algorithm cycles through various choices of capacitor weighting. (See the following section "Analog Input" for a detailed discussion of the $V_{\text {REF }}$ input characteristics.) The output impedance of the reference circuitry must be low so that the output voltage will remain sufficiently constant as the current drive changes. In some applications, this may require that the output of the voltage reference be buffered by an amplifier with low impedance at relatively high frequencies. In choosing a voltage reference, consideration should be
made for selecting one with low noise. A capacitor connected between REF IN and AGND will reduce the demands on the reference by decreasing the magnitude of high frequency components required to be sourced by the reference.

Figures 6 and 7 represent typical design approaches.


Figure 6.
Figure 6 shows a voltage reference circuit featuring the 5 V output AD586. The AD586 is a low cost reference which utilizes a buried Zener architecture to provide low noise and drift. Over the $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ range, the AD 586 M grade exhibits less than 1.0 mV output change from its initial value at $+25^{\circ} \mathrm{C}$. A noisereduction capacitor, $\mathrm{C}_{\mathrm{N}}$, reduces the broadband noise of the AD586 output, thereby optimizing the overall performance of the AD677. It is recommended that a $10 \mu \mathrm{~F}$ to $47 \mu \mathrm{~F}$ high quality tantalum capacitor and a $0.1 \mu \mathrm{~F}$ capacitor be tied between the $\mathrm{V}_{\text {REF }}$ input of the AD677 and ground to minimize the impedance on the reference.
Using the AD677 with $\pm 10 \mathrm{~V}$ input range $\left(\mathrm{V}_{\mathrm{REF}}=10 \mathrm{~V}\right)$ typically requires $\pm 15 \mathrm{~V}$ supplies to drive op amps and the voltage reference. If $\pm 12 \mathrm{~V}$ is not available in the system, regulators such as 78 L 12 and 79 L 12 can be used to provide power for the AD677. This is also the recommended approach (for any input range) when the ADC system is subjected to harsh environments such as where the power supplies are noisy and where voltage spikes are present. Figure 7 shows an example of such a system based upon the 10 V AD587 reference, which provides a $300 \mu \mathrm{~V}$ LSB. Circuitry for additional protection against power supply disturbances has been shown. A $100 \mu \mathrm{~F}$ capacitor at each


Figure 7.
regulator prevents very large voltage spikes from entering the regulators. Any power line noise which the regulators cannot eliminate will be further filtered by an RC filter ( $10 \Omega / 10 \mu \mathrm{~F}$ ) having a -3 dB point at 1.6 kHz . For best results the regulators should be within a few centimeters of the AD677.

## ANALOG INPUT

As previously discussed, the analog input voltage range for the AD677 is $\pm V_{\text {REF }}$. For purposes of ground drop and common mode rejection, the $\mathrm{V}_{\text {IN }}$ and $\mathrm{V}_{\text {REF }}$ inputs each have their own ground. $\mathrm{V}_{\text {REF }}$ is referred to the local analog system ground (AGND), and $\mathrm{V}_{\mathrm{IN}}$ is referred to the analog ground sense pin (AGND SENSE) which allows a remote ground sense for the input signal.
The AD677 analog inputs ( $\mathrm{V}_{\mathrm{IN}}, \mathrm{V}_{\text {REF }}$ and AGND SENSE) exhibit dynamic characteristics. When a conversion cycle begins, each analog input is connected to an internal, discharged 50 pF capacitor which then charges to the voltage present at the corresponding pin. The capacitor is disconnected when SAMPLE is taken LOW, and the stored charge is used in the subsequent conversion. In order to limit the demands placed on the external source by this high initial charging current, an internal buffer amplifier is employed between the input and this capacitance for a few hundred nanoseconds. During this time the input pin exhibits typically $20 \mathrm{k} \Omega$ input resistance, 10 pF input capacitance and $\pm 40 \mu \mathrm{~A}$ bias current. Next, the input is switched directly to the now precharged capacitor and allowed to fully settle. During this time the input sees only a 50 pF capacitor. Once the sample is taken, the input is internally floated so that the external input source sees a very high input resistance and a parasitic input capacitance of typically only 2 pF . As a result, the only dominant input characteristic which must be considered is the high current steps which occur when the internal buffers are switched in and out.

In most cases, these characteristics require the use of an external op amp to drive the input of the AD677. Care should be taken with op amp selection; even with modest loading conditions, most available op amps do not meet the low distortion requirements necessary to match the performance capabilities of the AD677. Figure 8 represents a circuit, based upon the AD845, which will provide excellent overall performance.

For applications optimized more for low distortion and low noise, the AD845 of Figure 8 may be replaced by the AD743.


Figure 8.

## AC PERFORMANCE

AC parameters, which include $\mathrm{S} /(\mathrm{N}+\mathrm{D})$, THD, etc., reflect the AD677's effect on the spectral content of the analog input signal. Figures 11 through 18 provide information on the AD677's ac performance under a variety of conditions.
A perfect n -bit ADC with no errors will yield a theoretical quantization noise of $q / \sqrt{12}$, where $q$ is the weight of the LSB. This relationship leads to the well-known equation for theoretical fullscale rms sine wave signal-to-noise plus distortion level of $\mathrm{S} /(\mathrm{N}+\mathrm{D})=6.02 \mathrm{n}+1.76 \mathrm{~dB}$, here n is the bit resolution. An actual ADC, however, will yield a measured $S /(N+D)$ less than the theoretical value. Solving this equation for $n$ using the measured $S /(N+D)$ value yields the equation for effective number of bits (ENOB):

$$
E N O B=\frac{[S /(N+D)]_{A C T U A L}-1.76 d B}{6.02}
$$

As a general rule, averaging the results from several conversions reduces the effects of noise, and therefore improves such parameters as $\mathrm{S} /(\mathrm{N}+\mathrm{D})$. AD677 performance may be optimized by operating the device at its maximum sample rate of 100 kSPS and digitally filtering the resulting bit stream to the desired signal bandwidth. This succeeds in distributing noise over a wider frequency range, thus reducing the noise density in the frequency band of interest. This subject is discussed in the following section.

## OVERSAMPLING AND NOISE FILTERING

The Nyquist rate for a converter is defined as one-half its sampling rate. This is established by the Nyquist theorem, which requires that a signal be sampled at a rate corresponding to at least twice its highest frequency component of interest in order to preserve the informational content. Oversampling is a conversion technique in which the sampling frequency is more than twice the frequency bandwidth of interest. In audio applications, the AD677 can operate at a $2 \times F_{S}$ oversampling rate, where $\mathrm{F}_{\mathrm{S}}=48 \mathrm{kHz}$.
In quantized systems, the informational content of the analog input is represented in the frequency spectrum from dc to the Nyquist rate of the converter. Within this same spectrum are higher frequency noise and signal components. Antialias, or low pass, filters are used at the input to the ADC to reduce these noise and signal components so that their aliased components do not corrupt the baseband spectrum. However, wideband noise contributed by the AD677 will not be reduced by the antialias filter. The AD677 quantization noise is evenly distributed from dc to the Nyquist rate, and this fact can be used to minimize its overall affect.
The AD677 quantization noise effects can be reduced by oversampling-sampling at a rate higher than that defined by the Nyquist theorem. This spreads the noise energy over a bandwidth wider than the frequency band of interest. By judicious selection of a digital decimation filter, noise frequencies outside the bandwidth of interest may be eliminated.
The process of analog to digital conversion inherently produces noise, known as quantization noise. The magnitude of this noise is a function of the resolution of the converter, and manifests itself as a limit to the theoretical signal-to-noise ratio achievable. This limit is described by $\mathrm{S} /(\mathrm{N}+\mathrm{D})=(6.02 \mathrm{n}+1.76+10 \log$ $\left.F_{S} / 2 F_{A}\right) d B$, where $n$ is the resolution of the converter in bits,
$\mathrm{F}_{\mathrm{S}}$ is the sampling frequency, and Fa is the signal bandwidth of interest. For audio bandwidth applications, the AD677 is capable of operating at a $2 \times$ oversample rate ( 96 kSPS ), which typically produces an improvement in $\mathrm{S} /(\mathrm{N}+\mathrm{D})$ of 3 dB compared with operating at the Nyquist conversion rate of 48 kSPS . Oversampling has another advantage as well; the demands on the antialias filter are lessened. In summary, system performance is optimized by running the AD677 at or near its maximum sampling rate of 100 kHz and digitally filtering the resulting spectrum to eliminate undesired frequencies.

## DC PERFORMANCE

The self-calibration scheme used in the AD677 compensates for bit weight errors that may exist in the capacitor array. This mismatch in capacitor values is adjusted (using the calibration coefficients) during conversion and provides for excellent dc linearity performance. Figure 19 illustrates the DNL plot of a typical AD677 at $+25^{\circ} \mathrm{C}$. A histogram test is a statistical method for deriving an A/D converter's differential nonlinearity. A ramp input is sampled by the ADC and a large number of conversions are taken and stored. Theoretically the codes would all be the same size and, therefore, have an equal number of occurrences. A code with an average number of occurrences would have a DNL of " 0 ". A code with more or less than average will have a DNL of greater than or less than zero LSB. A DNL of -1 LSB indicates missing code (zero occurrences).
Figure 20 illustrates the code width distribution of the DNL plots of Figure 19.

## DC CODE UNCERTAINTY

Ideally, a fixed dc input should result in the same output code for repetitive conversions. However, as a consequence of unavoidable circuit noise within the wideband circuits in the ADC, there is range of output codes which may occur for a given input voltage. If you apply a dc signal to the AD677 and record 10,000 conversions, the result will be a distribution of codes as shown in Figure 9 (using a 10 V reference). If you fit a Gaussian probability distribution to the histogram, the standard deviation is approximately equivalent to the rms input noise of ADC.


Figure 9. Distribution of Codes from 10,000 Conversions, Relative to the Correct Code

The standard deviation of this distribution is approximately 0.5 LSBs. If less uncertainty is desired, averaging multiple conversions will narrow this distribution by the inverse of the square root of the number of samples; i.e., the average of 4 conversions would have a standard deviation of 0.25 LSBs.

## DSP INTERFACE

Figure 10 illustrates the use of the Analog Devices ADSP-2101 digital signal processor with the AD677. The ADSP-2101 FO (flag out) pin of Serial Port 1 (SPORT 1) is connected to the SAMPLE line and is used to control acquisition of data. The ADSP-2101 timer is used to provide precise timing of the FO pin.


Figure 10. ADSP-2101 Interface
The SCLK pin of the ADSP-2101 SPORT0 provides the CLK input for the AD677. The clock should be programmed to be approximately 2 MHz to comply with AD677 specifications. To minimize digital feedthrough, the clock should be disabled (by setting Bit 14 in SPORT0 control register to 0 ) during data acquisition. Since the clock floats when disabled, a pull-down resistor of $12 \mathrm{k} \Omega-15 \mathrm{k} \Omega$ should be connected to SCLK to ensure it will be LOW at the falling edge of SAMPLE. To maximize the conversion rate, the serial clock should be enabled immediately after SAMPLE is brought LOW (hold mode).
The AD677 BUSY signal is connected to RF0 to notify SPORT0 when a new data word is coming. SPORT0 should be configured in normal, external, noninverting framing mode and can be programmed to generate an interrupt after the last data bit is received. To maximize the conversion rate, SAMPLE should be brought HIGH immediately after the last data bit is received.


Figure 11. $S /(N+D)$ and THD vs. $V_{\text {REF, }}, f_{S}=100 \mathrm{kHz}$ (Calibration is not guaranteed below +5V REF)


Figure 12. $S /(N+D)$ and $T H D$ vs. Input Amplitude, $f_{S}=100 \mathrm{kHz}$


Figure 13. 4096 Point FFT at $100 \mathrm{kSPS}, f_{\mathrm{IN}}=1 \mathrm{kHz}$, $V_{\text {REF }}=5 \mathrm{~V}$


Figure 14. 4096 Point FFT at $100 \mathrm{kSPS}, F_{I N}=1 \mathrm{kHz}, V_{\text {REF }}$ $=10 \mathrm{~V}$


Figure 15. AC Power Supply Rejection ( $f_{I N}=1.06 \mathrm{kHz}$ ) $f_{\text {SAMPLE }}=96 \mathrm{kSPS}, V_{\text {RIPPLE }}=0.13 \mathrm{Vp-p}$


Figure 16. IMD Plot for $f_{i N}=1008 \mathrm{~Hz}(f a), 1055 \mathrm{~Hz}(f b)$ àt 96 kSPS


Figure 17. $A C$ Performance vs. Clock Period, $T_{A}=$ $+85^{\circ} \mathrm{C}(5 \mathrm{~V}$ and 10 V Reference)


Figure 18. AC Performance Using Minimum Clock Period vs. Temperature ( $t_{C L K}=480 \mathrm{~ns}$ ), 5 V and 10 V Reference


Figure 19. DNL Plot at $V_{R E F}=10 \mathrm{~V}, T_{A}=+25^{\circ} \mathrm{C}, f_{S}=$ 100 kSPS


Figure 20. DNL Error Distribution (Taken from Figure 19)

## FEATURES

AC and DC Characterized and Specified<br>\section*{(K, B and T Grades)}<br>200k Conversions per Second<br>1 MHz Full Power Bandwidth<br>500 kHz Full Linear Bandwidth<br>72 dB S/N+D (K, B, T Grades)<br>Twos Complement Data Format (Bipolar Mode)<br>Straight Binary Data Format (Unipolar Mode)<br>$10 \mathrm{M} \Omega$ Input Impedance<br>8-Bit or 16-Bit Bus Interface<br>On-Board Reference and Clock<br>10 V Unipolar or Bipolar Input Range<br>Commercial, Industrial and Military Temperature Range Grades<br>MIL-STD-883 Compliant Versions Available

## PRODUCT DESCRIPTION

The AD678 is a complete, multipurpose 12 -bit monolithic analog-to-digital converter, consisting of a sample-hold amplifier (SHA), a microprocessor compatible bus interface, a voltage reference and clock generation circuitry.
The AD678 is specified for ac (or "dynamic") parameters such as $\mathrm{S} / \mathrm{N}+\mathrm{D}$ ratio, THD and IMD which are important in signal processing applications. In addition, the AD678K, B and T grades are fully specified for dc parameters which are important in measurement applications.
The AD678 offers a choice of digital interface formats; the 12 data bits can be accessed by a 16 -bit bus in a single read operation or by an 8 -bit bus in two read operations $(8+4)$, with right or left justification. Data format is straight binary for unipolar mode and twos complement binary for bipolar mode. The input has a full-scale range of 10 V with a full power bandwidth of 1 MHz and a full linear bandwidth of 500 kHz . High input impedance ( $10 \mathrm{M} \Omega$ ) allows direct connection to unbuffered sources without signal degradation.
This product is fabricated on Analog Devices' BiMOS process, combining low power CMOS logic with high precision, low noise bipolar circuits; laser-trimmed thin-film resistors provide high accuracy. The converter utilizes a recursive subranging algorithm which includes error correction and flash converter circuitry to achieve high speed and resolution.
The AD678 operates from +5 V and $\pm 12 \mathrm{~V}$ supplies and dissipates 560 mW (typ). The AD678 is available in 28-pin plastic DIP, ceramic DIP, and 44 J-leaded ceramic surface mount packages.
Screening to MIL-STD-883C Class B is also available.
*Protected by U.S. Patent Nos. 4,804,960; 4,814,767; 4,833,345; 4,250,445; 4,808,908; RE30,586.

FUNCTIONAL BLOCK DIAGRAM


## PRODUCT HIGHLIGHTS

1. COMPLETE INTEGRATION: The AD678 minimizes external component requirements by combining a high speed sample-hold amplifier (SHA), ADC, 5 V reference, clock and digital interface on a single chip. This provides a fully specified sampling A/D function unattainable with discrete designs.
2. SPECIFICATIONS: The AD678K, B and T grades provide fully specified and tested ac and dc parameters. The AD678J, A and S grades are specified and tested for ac parameters; dc accuracy specifications are shown as typicals. DC specifications (such as INL, gain and offset) are impor ${ }^{+}$ tant in control and measurement applications. AC specifications (such as $\mathrm{S} / \mathrm{N}+\mathrm{D}$ ratio, THD and IMD) are of value in signal processing applications.
3. EASE OF USE: The pinout is designed for easy board layout, and the choice of single or two read cycle output provides compatibility with 16 - or 8 -bit buses. Factory trimming eliminates the need for calibration modes or external trimming to achieve rated performance.
4. RELIABILITY: The AD678 utilizes Analog Devices' monolithic BiMOS technology. This ensures long term reliability compared to multichip and hybrid designs.
5. UPGRADE PATH: The AD678 provides the same pinout as the 14-bit, 128 kSPS AD679 ADC.
6. The AD678 is available in versions compliant with MIL-STD-883. Refer to the Analog Devices Military Products Databook or current AD678/883B data sheet for detailed specifications.

## AD678-SPECIFICATIONS



| Parameter | AD678J/A/S |  |  | AD678K/B/T |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max |  |
| SIGNAL-TO-NOISE AND DISTORTION (S/N+D) RATIO <br> -0.5 dB Input (Referred to -0 dB Input) <br> -20 dB Input (Referred to -20 dB Input) <br> -60 dB Input (Referred to -60 dB Input) | 70 | $\begin{aligned} & 71 \\ & 51 \\ & 11 \end{aligned}$ | , |  | $\begin{aligned} & 73 \\ & 53 \\ & 13 \end{aligned}$ |  | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \end{aligned}$ |
| TOTAL HARMONIC DISTORTION (THD) |  | $\begin{aligned} & -88 \\ & 0.004 \end{aligned}$ | $\begin{aligned} & -80 \\ & 0.010 \end{aligned}$ |  | $\begin{aligned} & -88 \\ & 0.004 \end{aligned}$ | $\begin{aligned} & -80 \\ & 0.010 \end{aligned}$ | $\begin{aligned} & \mathrm{dB} \\ & \% \end{aligned}$ |
| PEAK SPURIOUS OR PEAK HARMONIC COMPONENT |  | -87 | -80 |  | -87 | -80 | dB |
| FULL POWER BANDWIDTH |  | 1 |  |  | 1 |  | $\mathrm{MHz}^{\text {a }}$ |
| FULL LINEAR BANDWIDTH | 500 |  |  | 500 |  |  | kHz |
| ```INTERMODULATION DISTORTION (IMD) \({ }^{2}\) 2nd Order Products 3rd Order Products``` |  | $\begin{aligned} & -85 \\ & -90 \end{aligned}$ | $\begin{aligned} & -80 \\ & -80 \end{aligned}$ |  | -85 -90 | $\begin{aligned} & -80 \\ & -80 \end{aligned}$ | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \end{aligned}$ |

## NOTES

${ }^{1} \mathrm{f}_{\text {IN }}$ amplitude $=-0.5 \mathrm{~dB}(9.44 \mathrm{~V}$ p-p) bipolar mode full scale unless otherwise indicated. All measurements referred to a $-0 \mathrm{~dB}(9.997 \mathrm{~V}$ p-p) input signal unless otherwise indicated.
${ }^{2} f_{\mathrm{A}}=9.08 \mathrm{kHz}, \mathrm{f}_{\mathrm{B}}=9.58 \mathrm{kHz}$, with $\mathrm{f}_{\text {SAMPLE }}=200 \mathrm{kSPS}$.
Specifications subject to change without notice.

## DIGITAL SPECIFICATIONS (All device types $\mathrm{I}_{\min }$ to $\mathrm{T}_{\text {max }}, \mathrm{V}_{\mathrm{Cc}}=+12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{EE}}=-12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{DD}}=+5 \mathrm{~V} \pm 10 \%$ )

| Parameter | Test Conditions | Min | Max | Units |
| :---: | :---: | :---: | :---: | :---: |
| LOGIC INPUTS |  |  |  |  |
| $\mathrm{V}_{\mathrm{IH}} \quad$ High Level Input Voltage |  | 2.0 | $\mathrm{V}_{\text {D }}$ | V |
| $\mathrm{V}_{\text {IL }}$ " Low Level Input Voltage |  | 0 | 0.8 | V |
| $\mathrm{I}_{\mathrm{IH}} \quad$ High Level Input Current | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{DD}}$ | -10 | +10 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{IL}} \quad$ Low Level Input Current | $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ | -10 | +10 | $\mu \mathrm{A}$ |
| $\mathrm{C}_{\text {IN }} \quad$ Input Capacitance |  |  | 10 | pF |
| LOGIC OUTPUTS |  |  |  |  |
| $\mathrm{V}_{\mathrm{OH}} \quad$ High Level Output Voltage | $\mathrm{I}_{\mathrm{OH}}=0.1 \mathrm{~mA}$ | 4.0 |  | V |
|  | $\mathrm{I}_{\mathrm{OH}}=0.5 \mathrm{~mA}$ | 2.4 |  | V |
| $\mathrm{V}_{\text {OL }} \quad$ Low Level Output Voltage | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ |  | 0.4 | V |
| $\mathrm{I}_{\mathrm{OZ}} \quad$ High Z Leakage Current | $\mathrm{V}_{\text {IN }}=0$ or $\mathrm{V}_{\mathrm{DD}}$ | -10 | +10 | $\mu \mathrm{A}$ |
| $\mathrm{C}_{\mathrm{OZ}} \quad$ High Z Output Capacitance |  |  | 10 | pF |

[^10]DC SPECIFICATIONS $\left(T_{\min }\right.$ to $T_{\max }, V_{C C}=+12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{EE}}=-12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{DD}}=+5 \mathrm{~V} \pm 10 \%$ unless otherwise indicated)
$\left.\begin{array}{l|l|l|lll|l}\hline \text { Parameter } & \text { Min } & \begin{array}{c}\text { AD678J/A/S } \\ \text { Typ }\end{array} & \text { Max } & \text { Min } & \begin{array}{c}\text { AD678K/B/T } \\ \text { Typ }\end{array} & \text { Max }\end{array}\right]$ Units

[^11]TMMNG SPECIFICATIONS (All grades, $T_{\min }$ to $T_{\max }, V_{C C}=+12 \mathrm{~V} \pm 5 \%, V_{E E}=-12 \mathrm{~V} \pm 5 \%, V_{D D}=+5 \mathrm{~V} \pm 10 \%$ unless

| Parameter | Symbol | Min | Max | Units |
| :---: | :---: | :---: | :---: | :---: |
| $\overline{\overline{S C}}$ Delay | $\mathrm{t}_{\text {Sc }}$ | 50 |  | ns |
| Conversion Time | $\mathrm{t}_{\mathrm{C}}$ | 3.0 | 4.4 | $\mu \mathrm{s}$ |
| Conversion Rate ${ }^{1}$ | $\mathrm{t}_{\mathrm{CR}}$ |  | 5 | $\mu \mathrm{s}$ |
| Convert Pulse Width | $\mathrm{t}_{\mathrm{CP}}$ | 97 |  | ns |
| Aperture Delay | $\mathrm{t}_{\mathrm{AD}}$ | 5 | 20 | ns |
| Status Delay | $\mathrm{t}_{\text {SD }}$ | 0 | 400 | ns |
| Access Time ${ }^{2,3}$ | $\mathrm{t}_{\mathrm{BA}}$ | 10 | 100 | ns |
|  |  | 10 | $57^{4}$ | ns |
| Float Delay ${ }^{5}$ | $\mathrm{t}_{\mathrm{FD}}$ | 10 | 80 | ns |
| Output Delay | $t_{\text {OD }}$ |  | 0 | ns |
| Format Setup | $\mathrm{t}_{\text {FS }}$ | 47 |  | ns |
| $\overline{\mathrm{OE}}$ Delay | $\mathrm{t}_{\text {OE }}$ | 0 |  | ns |
| Read Pulse Width | $\mathrm{t}_{\mathrm{RP}}$ | 97 |  | ns |
| Conversion Delay | $\mathrm{t}_{\mathrm{CD}}$ | 150 |  | ns |
| EOCEN Delay | $\mathrm{t}_{\mathrm{EO}}$ | 0 |  | ns |

## NOTES

${ }^{1}$ Includes acquisition time.
${ }^{2}$ Measured from the falling edge of $\overline{\mathrm{OE}} / \overline{\mathrm{EOCEN}}(0.8 \mathrm{~V})$ to the time at which the data lines $/ \mathrm{EOC}$ cross 2.0 V or 0.8 V . See Figure 3.
${ }^{3} \mathrm{C}_{\text {OUT }}=100 \mathrm{pF}$.
${ }^{4} \mathrm{C}_{\text {OUT }}=50 \mathrm{pF}$.
${ }^{5}$ Measured from the rising edge of $\overline{\mathrm{OE}} / \overline{\mathrm{EOCEN}}(2.0 \mathrm{~V})$ to the time at which the output voltage changes by 0.5 V . See Figure $3 ; \mathrm{C}_{\mathrm{OUt}}=10 \mathrm{pF}$. Specifications subject to change without notice.


Figure 1. Conversion Timing


Figure 2. EOC Timing

| TEST | $\mathbf{V}_{\text {GP }}$ | $\mathbf{C}_{\text {OUT }}$ |
| :--- | :--- | :--- |
| ACCESS TIME HIGH Z TO LOGIC LOW | 5 V | 100 pF |
| FLOAT TIME LOGIC HIGH TO HIGH $Z$ | 0 V | 10 pF |
| ACCESS TIME HIGH Z TO LOGIC HIGH | 0 V | 100 pF |
| FLOAT TIME LOGIC LOW TO HIGH Z | $\mathbf{5 V}$ | 10 pF |



Figure 3. Load Circuit for Bus Timing Specifications

## ABSOLUTE MAXIMUM RATINGS*

| Specification | With <br> Respect <br> To | Min | Max | Units |
| :--- | :--- | :--- | :--- | :--- |
| $\mathrm{V}_{\mathrm{CC}}$ | AGND | -0.3 | +18 | V |
| $\mathrm{~V}_{\mathrm{EE}}$ | AGND | -18 | +0.3 | V |
| $\mathrm{~V}_{\mathrm{CC}}$ | $\mathrm{V}_{\mathrm{EE}}$ | -0.3 | +26.4 | V |
| $\mathrm{~V}_{\mathrm{DD}}$ | DGND | 0 | +7 | V |
| AGND | DGND | -1 | +1 | V |
| AIN, REF | IN | AGND | $\mathrm{V}_{\mathrm{EE}}$ | $\mathrm{V}_{\mathrm{CC}}$ |
| Digital Inputs <br> Digital Outputs <br> Max Junction | DGND | -0.5 | +7 | V |
| $\quad$ Temperature | DGND | -0.5 | $\mathrm{~V}_{\mathrm{DD}}+0.3$ | V |


| Specification | With <br> Respect <br> To | Min | Max | Units |
| :--- | :--- | :--- | :--- | :--- |
| Operating Temperature |  |  |  |  |
| $\quad$ J and K Grades |  | 0 | +70 | ${ }^{\circ} \mathrm{C}$ |
| A and B Grades |  | -40 | +85 | ${ }^{\circ} \mathrm{C}$ |
| S and T Grades |  | -55 | +125 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature <br> Lead Temperature <br> $(10$ sec max $)$ |  |  | +150 | ${ }^{\circ} \mathrm{C}$ |

*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## ESD SENSITIVITY

The AD678 features input protection circuitry consisting of large "distributed" diodes and polysilicon series resistors to dissipate both high energy discharges (Human Body Model) and fast, low energy pulses (Charged Device Model). Per Method 3015.2 of MIL-STD-883C, the AD678 has been classified as a Category 1 device.

Proper ESD precautions are strongly recommended to avoid functional damage or performance degradation. Charges as high as 4000 volts readily accumulate on the human body and test equipment and discharge without detection. Unused devices must be stored in conductive foam or
 shunts, and the foam should be discharged to the destination socket before devices are removed. For further information on ESD precautions, refer to Analog Devices' ESD Prevention Manual.

## ORDERING GUIDE

| Model $^{\mathbf{1}}$ | Package | Temperature Range | Tested and Specified | Package Option ${ }^{\mathbf{2}}$ |
| :--- | :--- | :--- | :--- | :--- |
| AD678JN | 28-Pin Plastic DIP | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | AC | $\mathrm{N}-28$ |
| AD678KN | 28-Pin Plastic DIP | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{AC}+\mathrm{DC}$ | $\mathrm{N}-28$ |
| AD678JD | 28-Pin Ceramic DIP | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | AC | $\mathrm{D}-28$ |
| AD678KD | 28-Pin Ceramic DIP | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | AC + DC | $\mathrm{D}-28$ |
| AD678AD | 28-Pin Ceramic DIP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | AC | $\mathrm{D}-28$ |
| AD678BD | 28-Pin Ceramic DIP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | AC + DC | $\mathrm{D}-28$ |
| AD678AJ | 44-Lead Ceramic JLCC | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | AC | $\mathrm{J}-44$ |
| AD678BJ | 44-Lead Ceramic JLCC | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | AC + DC | $\mathrm{J}-44$ |
| AD678SD | 28-Pin Ceramic DIP | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | AC | $\mathrm{D}-28$ |
| AD678TD | 28-Pin Ceramic DIP | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | AC + DC | D-28 |

## NOTES

${ }^{1}$ For details on grade and package offerings screened in accordance with MIL-STD-883, refer to Analog Devices Military Products Databook or /883 data sheet.
${ }^{2} \mathrm{~N}=$ Plastic DIP; D = Ceramic DIP; J = J-Leaded Ceramic Chip Carrier. For outline information see Package Information section.



FEATURES
AC and DC Characterized and Specified (K, B, T Grades)
128k Conversions per Second
1 MHz Full Power Bandwidth
500 kHz Full Linear Bandwidth
80 dB S/N+D (K, B, T Grades)
Twos Complement Data Format (Bipolar Mode)
Straight Binary Data Format (Unipolar Mode) $10 \mathrm{M} \Omega$ Input Impedance
8-Bit Bus Interface (See AD779 for 16-Bit Interface) On-Board Reference and Clock 10 V Unipolar or Bipolar Input Range
Pin Compatible with AD678 12-Bit, 200 kSPS ADC MIL-STD-883 Compliant Versions Available

## PRODUCT DESCRIPTION

The AD679 is a complete, multipurpose 14 -bit monolithic analog-to-digital converter, consisting of a sample-hold amplifier (SHA), a microprocessor compatible bus interface, a voltage reference and clock generation circuitry.
The AD679 is specified for ac (or "dynamic") parameters such as $\mathrm{S} / \mathrm{N}+\mathrm{D}$ ratio, THD and IMD which are important in signal processing applications. In addition, the AD679K, B and T grades are fully specified for dc parameters which are important in measurement applications.
The 14 data bits are accessed in two read operations ( $8+6$ ), with left justification. Data format is straight binary for unipolar mode and twos complement binary for bipolar mode. The input has a full-scale range of 10 V with a full power bandwidth of 1 MHz and a full linear bandwidth of 500 kHz . High input impedance ( $10 \mathrm{M} \Omega$ ) allows direct connection to unbuffered sources without signal degradation. Conversions can be initiated either under microprocessor control or by an external clock asynchronous to the system clock.
This product is fabricated on Analog Devices' BiMOS process, combining low power CMOS logic with high precision, low noise bipolar circuits; laser-trimmed thin-film resistors provide high accuracy. The converter utilizes a recursive subranging algorithm which includes error correction and flash converter circuitry to achieve high speed and resolution.
The AD679 operates from +5 V and $\pm 12 \mathrm{~V}$ supplies and dissipates 560 mW (typ.). 28-pin plastic DIP, ceramic DIP and 44 J-leaded ceramic surface mount packages are available.

[^12]FUNCTIONAL BLOCK DIAGRAM


## PRODUCT HIGHLIGHTS

1. COMPLETE INTEGRATION: The AD679 minimizes external component requirements by combining a high speed sample-hold amplifier (SHA), ADC, 5 V reference, clock and digital interface on a single chip. This provides a fully specified sampling A/D function unattainable with discrete designs.
2. SPECIFICATIONS: The AD679K, B and T grades provide fully specified and tested ac and dc parameters. The AD679J, A and S grades are specified and tested for ac parameters; dc accuracy specifications are shown as typicals. DC specifications (such as INL, gain and offset) are important in control and measurement applications. AC specifications (such as $\mathrm{S} / \mathrm{N}+\mathrm{D}$ ratio, THD and IMD) are of value in signal processing applications.
3. EASE OF USE: The pinout is designed for easy board layout, and the two read output provides compatibility with 8 -bit buses. Factory trimming eliminates the need for calibration modes or external trimming to achieve rated performance.
4. RELIABILITY: The AD679 utilizes Analog Devices' monolithic BiMOS technology. This ensures long term reliability compared to multichip and hybrid designs.
5. UPGRADE PATH: The AD679 provides the same pinout as the 12 -bit, 200 kSPS AD678 ADC.
6. The AD679 is available in versions compliant with MIL-STD-883. Refer to the Analog Devices Military Products Databook or current AD679/883B data sheet for detailed specifications.

[^13]


| Parameter | AD679J/A/S |  |  | AD679K/B/T |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max |  |
| SIGNAL-TO-NOISE AND DISTORTION (S/N+D) RATIO |  |  |  |  |  |  |  |
| -0.5 dB Input (Referred to -0 dB Input) | 78 | 79 |  | 80 | 81 |  | dB |
| -20 dB Input (Referred to -20 dB Input) | 58 | 59 |  | 60 | 61 |  | dB |
| -60 dB Input (Referred to -60 dB Input) | 18 | 19 |  | 20 | 21 |  | dB |
| TOTAL HARMONIC DISTORTION (THD) |  |  |  |  |  |  |  |
| $@+25^{\circ} \mathrm{C}$ |  | -90 | -84 |  | -90 | -84 | dB |
|  |  | 0.003 | 0.006 |  | 0.003 | 0.006 | \% |
| $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |  | -88 | -82 |  | -88 | -82 | dB |
|  |  | 0.004 | 0.008 |  | 0.004 | 0.008 | \% |
| PEAK SPURIOUS OR PEAK HARMONIC COMPONENT |  | -90 | -84 |  | -90 | -84 | dB |
| FULL POWER BANDWIDTH |  | 1 |  |  | 1 |  | MHz |
| FULL LINEAR BANDWIDTH | 500 |  |  | 500 |  |  | kHz |
| INTERMODULATION DISTORTION (IMD) ${ }^{2}$ |  |  |  |  |  |  |  |
| 2nd Order Products |  | -90 | -84 |  | -90 | -84 | dB |
| 3rd Order Products |  | -90 | -84 |  | -90 | -84 | dB |

## D|GITAL SPECIFICATIONS (All device types $\mathrm{T}_{\mathrm{MIN}}$ to $\mathrm{T}_{\mathrm{MAX}}, \mathrm{V}_{\mathrm{CC}}=+12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{EE}}=-12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{DD}}=+5 \mathrm{~V} \pm 10 \%$ )

| Parameter | Test Conditions | Min | Max | Units |
| :---: | :---: | :---: | :---: | :---: |
| LOGIC INPUTS |  |  |  |  |
| $\mathrm{V}_{\mathrm{IH}} \quad$ High Level Input Voltage |  | 2.0 | $\mathrm{V}_{\mathrm{DD}}$ | V |
| $\mathrm{V}_{\mathrm{IL}} \quad$ Low Level Input Voltage |  | 0 | 0.8 | V |
| $\mathrm{I}_{\text {IH }} \quad$ High Level Input Current | $\mathrm{V}_{\text {IN }}=5 \mathrm{~V}$ | -10 | +10 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{IL}} \quad$ Low Level Input Current | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}$ | -10 | +10 | $\mu \mathrm{A}$ |
| $\mathrm{C}_{\text {IN }} \quad$ Input Capacitance |  |  | 10 | pF |
| LOGIC OUTPUTS |  |  |  |  |
| $\mathrm{V}_{\mathrm{OH}} \quad$ High Level Output Voltage | $\mathrm{I}_{\mathrm{OH}}=0.1 \mathrm{~mA}$ | 4.0 |  | V |
|  | $\mathrm{I}_{\mathrm{OH}}=0.5 \mathrm{~mA}$ | 2.4 |  | V |
| $\mathrm{V}_{\text {OL }} \quad$ Low Level Output Voltage | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ |  | 0.4 | V |
| $\mathrm{I}_{\mathrm{OZ}} \quad$ High Z Leakage Current | $\mathrm{V}_{\mathrm{IN}}=0$ or 5 V | -10 | +10 | $\mu \mathrm{A}$ |
| $\mathrm{C}_{\mathrm{OZ}} \quad$ High Z Output Capacitance |  |  | 10 | pF |

NOTES
${ }^{1} \mathrm{f}_{\mathrm{IN}}$ amplitude $=-0.5 \mathrm{~dB}(9.44 \mathrm{~V}$ p-p) bipolar mode full scale unless otherwise indicated. All measurements referred to a -0 dB ( 9.997 V p-p) input signal unless otherwise noted.
${ }^{2} \mathrm{f}_{\mathrm{A}}=9.08 \mathrm{kHz}, \mathrm{f}_{\mathrm{B}}=9.58 \mathrm{kHz}$, with $\mathrm{f}_{\text {SAMPLE }}=100 \mathrm{kSPS}$.
Specifications subject to change without notice.
 C SPECIFICAIINS otherwise indicated)

| Parameter | AD679J/A/S |  |  | AD679K/B/T |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max |  |
| TEMPERATURE RANGE |  |  |  |  |  |  |  |
| J, K Grades | 0 |  | +70 | 0 |  | +70 | ${ }^{\circ} \mathrm{C}$ |
| A, B Grades | -40 |  | +85 | -40 |  | +85 | ${ }^{\circ} \mathrm{C}$ |
| S, T Grades | -55 |  | +125 | -55 |  | $+125$ | ${ }^{\circ} \mathrm{C}$ |
| ACCURACY |  |  |  |  |  |  |  |
| Resolution | 14 |  |  | 14 |  |  | Bits |
| Integral Nonlinearity (INL) |  | $\pm 2$ |  |  | $\pm 1$ | $\pm 2$ | LSB |
| Differential Nonlinearity (DNL) | 14 |  |  | 14 |  |  | Bits |
| Unipolar Zero Error ${ }^{1}$ (@+25 ${ }^{\circ} \mathrm{C}$ ) |  | 0.08 |  |  | 0.05 | 0.07 | \% FSR* |
| Bipolar Zero Error ${ }^{1}\left(@+25^{\circ} \mathrm{C}\right)$ |  | 0.08 |  |  | 0.05 | 0.07 | \% FSR |
| Gain Error ${ }^{1,2}$ (@+25${ }^{\circ}$ ) |  | 0.12 |  |  | 0.09 | 0.11 | \% FSR |
| Temperature Drift |  |  |  |  |  |  |  |
| Unipolar Zero ${ }^{3}$ |  |  |  |  |  |  |  |
| J, K Grades |  | 0.04 |  |  | 0.04 | 0.05 | \% FSR |
| A, B Grades |  | 0.05 |  |  | 0.05 | 0.07 | \% FSR |
| S, T Grades |  | 0.09 |  |  | 0.09 | 0.10 | \% FSR |
| Bipolar Zero ${ }^{3}$ |  |  |  |  |  |  |  |
| J, K Grades |  | 0.02 |  |  | 0.02 | 0.04 | \% FSR |
| A, B Grades |  | 0.04 |  |  | 0.04 | 0.05 | \% FSR |
| S, T Grades |  | 0.08 |  |  | 0.08 | 0.09 | \% FSR |
|  |  |  |  |  |  |  |  |
| J, K Grades |  | 0.09 |  |  | 0.09 | 0.11 | \% FSR |
| A, B Grades |  | 0.10 |  |  | 0.10 | 0.16 | \% FSR |
| $\mathrm{S}, \mathrm{T}$ Grades |  | 0.20 |  |  | 0.20 | 0.25 | \% FSR |
| Gain ${ }^{4}$ |  |  |  |  |  |  |  |
| J, K Grades |  | 0.04 |  |  | 0.04 | 0.05 | \% FSR |
| A, B Grades |  | 0.05 |  |  | 0.05 | 0.07 | \% FSR |
| S, T Grades |  | 0.09 |  |  | 0.09 | 0.10 | \% FSR |
| ANALOG INPUT |  |  |  |  |  |  |  |
| Input Ranges |  |  |  |  |  |  |  |
|  |  |  |  |  |  |  |  |
|  |  |  |  |  |  |  |  |
| Input Resistance |  | 10 |  |  | 10 |  | $\mathrm{M} \Omega$ |
|  |  |  |  |  |  |  |  |
|  |  |  |  |  |  |  |  |
| Aperture Delay |  | 10 |  |  | 10 |  | ns |
| Aperture Jitter |  | 150 |  |  | 150 |  | ps |
| INTERNAL VOLTAGE REFERENCE |  |  |  |  |  |  |  |
| Output Voltage ${ }^{5}$ | 4.98 |  | 5.02 | 4.98 |  | 5.02 | V |
| External Load |  |  |  |  |  |  |  |
| Unipolar Mode |  |  | +1.5 |  |  | +1.5 | mA |
| Bipolar Mode |  |  | +0.5 |  |  | +0.5 | mA |
| POWER SUPPLIES |  |  |  |  |  |  |  |
| Power Supply Rejection |  |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{CC}}=+12 \mathrm{~V} \pm 5 \%$ |  | $\pm 6$ |  |  |  | $\pm 6$ | LSB |
| $\mathrm{V}_{\mathrm{EE}}=-12 \mathrm{~V} \pm 5 \%$ |  | $\pm 6$ |  |  |  | $\pm 6$ | LSB |
| $\mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V} \pm 10 \%$ |  | $\pm 6$ |  |  |  | $\pm 6$ | LSB |
| Operating Current |  |  |  |  |  |  |  |
| $\mathrm{I}_{\mathrm{CC}}$ |  | 18 | 20 |  | 18 | 20 | mA |
| $\mathrm{I}_{\text {EE }}$ |  | 25 | 34 |  | 25 | 34 | mA |
| $\mathrm{I}_{\mathrm{DD}}$ |  | 8 | 12 |  | 8 | 12 | mA |
| Power Consumption |  | 560 | 745 |  | 560 | 745 | mW |

[^14]
## TIMING SPECIFICATIONS

(All device types $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\mathrm{MAX}}, \mathrm{V}_{\mathrm{CC}}=+12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{EE}}=-12 \mathrm{~V}$ $\pm 5 \%, V_{D D}=+5 \mathrm{~V} \pm 10 \%$ )

| Parameter | Symbol | Min | Max | Units |
| :--- | :--- | :--- | :--- | :--- |
| $\overline{\overline{S C}}$ Delay | $\mathrm{t}_{\mathrm{SC}}$ | 50 |  | ns |
| Conversion Time | $\mathrm{t}_{\mathrm{C}}$ |  | 6.3 | $\mu \mathrm{~s}$ |
| Conversion Rate | $\mathrm{t}_{\mathrm{CR}}$ |  | 7.8 | $\mu \mathrm{~s}$ |
| Convert Pulse Width | $\mathrm{t}_{\mathrm{CP}}$ | 0.097 | 3.0 | $\mu \mathrm{~s}$ |
| Aperture Delay | $\mathrm{t}_{\mathrm{AD}}$ | 5 | 20 | ns |
| Status Delay | $\mathrm{t}_{\mathrm{SD}}$ | 0 | 400 | ns |
| Access Time ${ }^{2.3}$ | $\mathrm{t}_{\mathrm{BA}}$ | 10 | 100 | ns |
|  |  | 10 | $57^{+}$ | ns |
| Float Delay $^{5}$ | $\mathrm{t}_{\mathrm{FD}}$ | 10 | 80 | ns |
| Output Delay | $\mathrm{t}_{\mathrm{OD}}$ |  | 0 | ns |
| Format Setup | $\mathrm{t}_{\mathrm{FS}}$ | 100 |  | ns |
| OE Delay | $\mathrm{t}_{\mathrm{OE}}$ | 20 |  | ns |
| Read Pulse Width | $\mathrm{t}_{\mathrm{RP}}$ | 195 |  | ns |
| Conversion Delay | $\mathrm{t}_{\mathrm{CD}}$ | 400 |  | ns |
| EOCEN Delay | $\mathrm{t}_{\mathrm{EO}}$ | 50 |  | ns |

## NOTES

${ }^{1}$ Includes Acquisition Time.
${ }^{2}$ Measured from the falling edge of $\overline{\mathrm{OE}} / \overline{\mathrm{EOCEN}}(0.8 \mathrm{~V})$ to the time at which the data lines/EOC cross 2.0 V or 0.8 V . See Figure 4.
${ }^{3} \mathrm{C}_{\mathrm{OLT}}=100 \mathrm{pF}$.
${ }^{4} \mathrm{C}_{\mathrm{OLT}}=50 \mathrm{pF}$.
${ }^{5}$ Measured from the rising edge of $\overline{\mathrm{OE}} / \overline{\mathrm{EOCEN}}(2.0 \mathrm{~V})$ to the time at which the output voltage changes by 0.5 . See Figure $4 ; \mathrm{C}_{\mathrm{OUT}}=10 \mathrm{pF}$.
Specifications subject to change without notice.

## ORDERING GUIDE ${ }^{\mathbf{1}}$

| Model ${ }^{2}$ | Package | Temperature Range | Tested and Specified | Package Option ${ }^{3}$ |
| :---: | :---: | :---: | :---: | :---: |
| AD679JN | 28-Pin Plastic DIP | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | AC | N-28 |
| AD679KN | 28-Pin Plastic DIP | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | AC + DC | $\mathrm{N}-28$ |
| AD679JD | 28-Pin Ceramic DIP | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | AC | D-28 |
| AD679KD | 28-Pin Ceramic DIP | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | AC + DC | D-28 |
| AD679AD | 28-Pin Ceramic DIP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | AC | D-28 |
| AD679BD | 28-Pin Ceramic DIP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{AC}+\mathrm{DC}$ | D-28 |
| AD679SD | 28-Pin Ceramic DIP | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | AC | D-28 |
| AD679TD | 28-Pin Ceramic DIP | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | AC + DC | D-28 |
| AD679AJ | 44-Lead Ceramic JLCC | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | AC | J-44 |
| AD679BJ | 44-Lead Ceramic JLCC | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $A C+D C$ | J-44 |
| AD679SJ | 44-Lead Ceramic JLCC | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | AC | J-44 |
| AD679TJ | 44-Lead Ceramic JLCC | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $A C+D C$ | J-44 |

## NOTES

${ }^{1}$ For parallel read (14-Bits) interface to 16 -bit buses, see AD779.
${ }^{2}$ For details grade and package offerings screened in accordance with MIL-STD-883, refer to the Analog Devices Miliary Products Databook or current AD679/883B data sheet.
${ }^{3} \mathrm{~N}=$ Plastic DIP; D = Ceramic DIP; J = J-Leaded Ceramic Chip Carrier.
For outline information see Package Information section.


Figure 1. Conversion Timing


Figure 2. Output Timing


## NOTE

'EOC IS A THREE-STATE OUTPUT IN SYNCHRONOUS
MODE AND AN OPEN DRAIN OUTPUT IN ASYNCHRO.
NOUS. ACCESS ( $t_{\text {B }}$ ) AND FLOAT ( $t_{\text {tol }}$ ) TIMING SPECIFI-
CATIONS DO NOT APPLY IN ASYNCHRONOUS MODE
WHERE THEY ARE A FUNCTION THE TIME CONSTANT
FORMED BY THE 10 PF OUTPUT CAPACITANCE AND THE PULL-UP RESISTOR.

Figure 3. EOC Timing


Figure 4. Load Circuit for Bus Timing Specifications

ABSOLUTE MAXIMUM RATINGS*

| Specification | With <br> Respect <br> To | Min | Max | Units |
| :--- | :--- | :--- | :--- | :--- |
| $\mathrm{V}_{\mathrm{CC}}$ | AGND | -0.3 | +18 | V |
| $\mathrm{~V}_{\mathrm{EE}}$ | AGND | -18 | +0.3 | V |
| $\mathrm{~V}_{\mathrm{CC}}$ (Note 1) | $\mathrm{V}_{\mathrm{EE}}$ | -0.3 | +26.4 | V |
| $\mathrm{~V}_{\mathrm{DD}}$ | DGND | 0 | +7 | V |
| AGND | DGND | -1 | +1 | V |
| AIN, REF |  |  |  |  |
| Digital Inputs | AGND | $\mathrm{V}_{\mathrm{EE}}$ | $\mathrm{V}_{\mathrm{CC}}$ | V |
| Digital Outputs | DGND | -0.5 | +7 | V |
| Max Junction <br> $\quad$ Temperature | DGND | -0.5 | $\mathrm{~V}_{\mathrm{DD}}+0.3$ | V |


|  | With <br> Respect <br> To | Min | Max | Units |
| :--- | :--- | :--- | :--- | :--- |
| Specification |  |  |  |  |
| Operating |  | 0 | +70 | ${ }^{\circ} \mathrm{C}$ |
| Temperature |  |  |  |  |
| $\quad$ J and K Grades |  | -40 | +85 | ${ }^{\circ} \mathrm{C}$ |
| A and B Grades |  | -55 | +125 | ${ }^{\circ} \mathrm{C}$ |
| $\quad$ S and T Grades |  |  |  |  |
| Storage Temperature |  | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |
| Lead Temperature |  |  | +300 | ${ }^{\circ} \mathrm{C}$ |
| $(10$ sec max $)$ |  |  |  |  |

## NOTES

*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{1}$ The AD679 is not designed to operate from $\pm 15 \mathrm{~V}$ supplies.

## ESD SENSITIVITY

The AD679 features input protection circuitry consisting of large "distributed" diodes and polysilicon series resistors to dissipate both high energy discharges (Human Body Model) and fast, low energy pulses (Charged Device Model). Per Method 3015.2 of MIL-STD-883C, the AD679 has been classified as a Category 1 device.
Proper ESD precautions are strongly recommended to avoid functional damage or performance degradation. Charges as high as 4000 volts readily accumulate on the human body and test equipment and discharge without detection. Unused devices must be stored in conductive foam or
 shunts, and the foam should be discharged to the destination socket before devices are removed. For further information on ESD precautions, refer to Analog Devices' ESD Prevention Manual.

## PIN DESIGNATIONS



NC = NO CONNECT

## FEATURES

Monolithic 10-Bit 20 MSPS A/D Converter
Low Power Dissipation: 1.0 W
Signal-to-Noise Plus Distortion Ratio
$f_{I_{N}}=1 \mathrm{MHz}: 56 \mathrm{~dB}$
$f_{\mathrm{IN}}=10 \mathrm{MHz}: 54 \mathrm{~dB}$
Guaranteed No Missing Codes
On-Chip Track-and-Hold Amplifier
100 MHz Full Power Bandwidth
High Impedance Reference Input
Out of Range Output
Twos Complement and Binary Output Data
Available in Commercial and Military Temperature Ranges (See Military/Aerospace Reference Manual for Specifications)

## PRODUCT DESCRIPTION

The AD773A is a monolithic 10 -bit, 20 Msps analog-to-digital converter incorporating an on-board, high performance track-and-hold amplifier (THA). The AD773A converts video bandwidth signals without the use of an external THA. The AD773A implements a multistage differential pipelined architecture with output error correction logic. The AD773A offers accurate performance and guarantees no missing codes over the full operating temperature range.
Output data is presented in binary and twos complement format. An out of range (OTR) signal indicates the analog input voltage is beyond the specified input range. OTR can be decoded with the MSB/ $\overline{M S B}$ pins to signal an underflow or overflow condition. The high impedance reference input allows multiple AD773As to be driven in parallel from a single reference.

The combined dc precision and dynamic performance of the AD773A is useful in a variety of applications. Typical applications include: video enhancement, HDTV, ghost cancellation, ultrasound imaging, radar and high speed data acquisition.
The AD773A was designed using Analog Devices' ABCMOS-1 process which utilizes high speed bipolar and 2-micron CMOS transistors on a single chip. High speed, precision analog circuits are now combined with high density logic circuits. Laser trimmed thin film resistors are used to optimize accuracy and temperature stability.
The AD773A is packaged in a 28 -pin ceramic DIP and is available in commercial $\left(0^{\circ} \mathrm{C}\right.$ to $\left.+70^{\circ} \mathrm{C}\right)$ and military $\left(-55^{\circ} \mathrm{C}\right.$ to $+125^{\circ} \mathrm{C}$ ) grades.

## FUNCTIONAL BLOCK DIAGRAM



## PRODUCT HIGHLIGHTS

1. On-board THA

The high impedance differential input THA eliminates the need for external buffering or sample and hold amplifiers. The THA offers the choice of differential or single-ended inputs. Input current is typically $5 \mu \mathrm{~A}$.
2. High Impedance Reference Input The high impedance reference input ( $200 \mathrm{k} \Omega$ ) allows direct connection with standard +2.5 V references, such as the AD680, AD580 and REF43.
3. Output Data Flexibility

Output data is available in bipolar offset and bipolar twos complement binary format.
4. Out of Range (OTR)

The OTR output bit indicates when the input signal is beyond the AD773A's input range.
5. Military Temperature Range

## AD773A - SPECIFICATIONS



| Parameter | AD773AJ |  |  | AD773AK |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max |  |
| RESOLUTION | 10 |  |  | 10 |  |  | Bits |
| DC ACCURACY |  |  |  |  |  |  |  |
| Integral Nonlinearity |  |  |  |  |  |  | LSB |
| $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |  | $\pm 0.75$ |  |  | $\pm 0.75$ | $\pm 2$ | LSB |
| Differential Linearity Error |  |  |  |  |  |  | LSB |
| $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |  | $\pm 0.75$ |  |  | $\pm 0.75$ | $\pm 1$ | LSB |
| Zero Error |  | 0.5 |  |  | 0.5 | 3.5 | \% FSR |
| Gain Error |  | 0.5 |  |  | 0.5 | 3.0 | \% FSR |
| No Missing Codes |  |  |  |  | RANT |  |  |
| ANALOG INPUT |  |  |  |  |  |  |  |
| Input Range |  | 1 |  |  | 1 |  | V p-p |
| Input Current |  | 5 | 20 |  | 5 | 20 | $\mu \mathrm{A}$ |
| Input Capacitance |  |  | 10 |  |  | 10 | pF |
| REFERENCE INPUT |  |  |  |  |  |  |  |
| Reference Input Resistance | 50 | 200 |  | 50 | 200 |  | k $\Omega$ |
| Reference Input |  | 2.5 |  |  | 2.5 |  | Volts |
| LOGIC INPUT |  |  |  |  |  |  |  |
| High Level Input Voltage | +3.5 |  |  | +3.5 |  |  | V |
| Low Level Input Voltage |  |  | +0.5 |  |  | $+0.5$ | V |
| High Level Input Current ( $\mathrm{V}_{\mathbf{I N}}=\mathrm{DV}_{\mathrm{DD}}$ ) | -10 |  | +10 | -10 |  | +10 | $\mu \mathrm{A}$ |
| Low Level Input Current ( $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}$ ) | -10 |  | +10 | -10 |  | $+10$ | $\mu \mathrm{A}$ |
| Input Capacitance |  | 10 |  |  | 10 |  | pF |
| LOGIC OUTPUTS |  |  |  |  |  |  |  |
| High Level Output Voltage ( $\mathrm{I}_{\mathrm{OH}}=0.5 \mathrm{~mA}$ ) | +2.4 |  |  | +2.4 |  |  | V |
| Low Level Output Voltage ( $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ ) |  |  | +0.4 |  |  | +0.4 | V |
| POWER SUPPLIES |  |  |  |  |  |  |  |
| Operating Voltages |  |  |  |  |  |  |  |
| $\mathrm{AV}_{\text {DD }}$ | +4.75 |  | +5.25 | +4.75 |  | +5.25 | Volts |
| $\mathrm{AV}_{\text {ss }}$ | -5.25 |  | -4.75 | -5.25 |  | -4.75 | Volts |
| DV ${ }_{\text {DD }}$, DRV $_{\text {DD }}$ | +4.75 |  | +5.25 | +4.75 |  | +5.25 | Volts |
| Operating Current |  |  |  |  |  |  |  |
| $\mathrm{IAV}_{\text {DD }}$. |  | 65 | 80 |  | 65 | 80 | mA |
| $\mathrm{IAV}_{\text {ss }}$ |  | -115 | -140 |  | -115 | -140 | mA |
| $\mathrm{IDV}_{\text {DD }}$ |  | 10 | 20 |  | 10 | 20 | mA |
| $\mathrm{IDRV}_{\text {DD }}{ }^{1}$ |  | 10 | 15 |  | 10 | 15 | mA |
| POWER CONSUMPTION ${ }^{2}$ |  | 1.0 | 1.2 |  | 1.0 | 1.2 | W |
| POWER SUPPLY REJECTION |  | 10 | 18 |  | 10 | 18 | $\mathrm{mV} / \mathrm{V}$ |
| TEMPERATURE RANGE Specified (J/K) | 0 |  | +70 | 0 |  | +70 | ${ }^{\circ} \mathrm{C}$ |

## NOTES

${ }^{1} \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$.
${ }^{2} 100 \%$ production tested.
Specifications subject to change without notice. See Definition of Specifications for additional information.


|  | AD773AJ <br> Typ |  | Max | Min | AD773AK <br> Typ | Max |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | Units

NOTES
${ }^{1}$ For typical dynamic performance curves at $\mathrm{f}_{\text {SAMPLE }}=20 \mathrm{Msps}$ see Figures 2 through 7.
${ }^{2} \mathrm{f}_{\mathrm{IN}}=1 \mathrm{MHz}$.
${ }^{3} \mathrm{fa}=1.0 \mathrm{MHz}, \mathrm{fb}=1.05 \mathrm{MHz}$.
Specifications subject to change without notice.
TIMING SPECIFICATIONS (for all grades $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAx }}$ with $\mathrm{AV}_{\mathrm{DD}}=+5 \mathrm{~V} \pm 5 \%, \mathrm{AV}_{S S}=-5 \mathrm{~V} \pm 5 \%$, $\mathrm{DV} \mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V} \pm 5 \%$,

|  | Symbol | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Conversion Rate |  |  |  | 20 | Msps |
| Clock Period | $\mathrm{t}_{\text {CLK }}$ | 50 |  |  |  |
| Clock High | $\mathrm{t}_{\mathrm{CH}}$ | 24.5 |  |  |  |
| Clock Low | $\mathrm{t}_{\mathrm{CL}}$ | 24.5 |  |  |  |
| Output Delay | $t_{\text {OD }}$ |  | 20 |  |  |
| Aperture Delay |  |  | 7 |  |  |
| Aperture Jitter ${ }^{\text {Pipeline Delay (Latency) }}$ |  |  | 9 |  | ps |
| Pipeline Delay (Latency) |  |  |  | 4 | Clock Cycles |



Figure 1. AD773A Timing Diagram

CAUTION
ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD773A features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

## ABSOLUTE MAXIMUM RATINGS*

| Parameter | With Respect to | Min | Max | Units |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{AV}_{\text {DD }}$ | AGND | -0.5 | +6.5 | V |
| $\mathrm{AV}_{\text {ss }}$ | AGND | -6.5 | +0.5 | V |
| $\mathrm{V}_{\text {INA }}, \mathrm{V}_{\text {INB }}$ | AGND | -6.5 | +6.5 | V |
| $\mathrm{DV}_{\text {DD }}, \mathrm{DRV}_{\text {DD }}$ | DGND, DRGND | -0.5 | +6.5 | V |
| AGND | DGND, DRGND | -1.0 | +1.0 | V |
| $\mathrm{AV}_{\text {DD }}$ | $\mathrm{DV}_{\mathrm{DD}}, \mathrm{DRV}^{\text {DD }}$ | -6.5 | +0.5 | V |
| CLK | $\mathrm{DV}_{\text {DD }}, \mathrm{DRV}_{\text {DD }}$ | -6.5 | +0.5 | V |
| REFIN | REFGND, AGND | -0.5 | +6.5 | V |
| Junction Temperature |  |  | +150 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature |  | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |
| Lead Temperature $(10 \mathrm{sec})$ |  |  | +300 | ${ }^{\circ} \mathrm{C}$ |

*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum ratings for extended periods may affect device reliability.

ORDERING GUIDE ${ }^{1}$

| Model | Temperature <br> Range | Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD773AJD | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 28-Pin Ceramic DIP | D-28 |
| AD773AKD | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 28-Pin Ceramic DIP | D-28 |

NOTES
${ }^{1}$ See Military/Aerospace Reference Manual for AD773ASD/883B specifications.
${ }^{2} \mathrm{D}=$ Ceramic DIP. For outline information see Package Information section.

PIN CONFIGURATION


## PIN DESCRIPTION

| Symbol | Pin No. | Type | Name and Function |
| :--- | :--- | :--- | :--- |
| AGND | 5,28 | P | Analog Ground. |
| AV $_{\text {DD }}$ | 4 | P | +5 V Analog Supply. |
| AV $_{\text {SS }}$ | 3,25 | P | -5 V Analog Supply. |
| MSB | 19 | DO | Inverted Most Significant Bit. Provides twos complement output data format. |
| OTR | 20 | DO | Out of Range is Active HIGH on the leading edge of Code 0 or the trailing edge of Code 1023. <br> See Output Data Format Table II. |
| BIT 1 (MSB) | 18 | DO | Most Significant Bit. |
| BIT 2-BIT 9 | $17-10$ | DO | Data Bit 2 through Data Bit 9. |
| BIT 10 (LSB) | 9 | DO | Least Significant Bit. |
| CLK | 23 | DI | Clock Input. The AD773A will initiate a conversion on the falling edge of the clock input. See the |
|  |  |  | Timing Diagram for details. |
| DV | 24 | P | +5 V Digital Supply. |
| DRV | 7,22 | P | +5 V Digital Supply for the output drivers. |
| DGND | 6 | P | Digital Ground. |
| DRGND | 8,21 | P | Digital Ground for the output drivers. |
| REFGND | 1 | AI | REFGND is connected to the ground of the external reference. |
| REFIN | 2 | AI | REFIN is the external 2.5 V reference input, taken with respect to REFGND. |
| V $_{\text {INA }}$ | 26 | AI | (+) Analog input signal to the differential input THA. |
| V $_{\text {INB }}$ | 27 | AI | (-) Analog input signal to the differential input THA. |

Type: $\mathrm{AI}=$ Analog Input; $\mathrm{DI}=$ Digital Input; $\mathrm{DO}=$ Digital Output; $\mathbf{P}=$ Power.

## Definitions of Specifications—AD773A

## INTEGRAL NONLINEARITY (INL)

Linearity error refers to the deviation of each individual code from a line drawn from "zero" through "full scale." The point used as "zero" occurs $1 / 2$ LSB before the first code transition. "Full scale" is defined as a level $11 / 2$ LSB beyond the last code transition. The deviation is measured from the center of each particular code to the true straight line.

## DIFFERENTIAL LINEARITY ERROR (DNL, NO MISSING CODES)

An ideal ADC exhibits code transitions that are exactly 1 LSB apart. DNL is the deviation from this ideal value.

## ZERO EROR

The major carry transition should occur for an analog value $1 / 2$ LSB below analog common. Zero error is defined as the deviation of the actual transition from that point.

## GAIN ERROR

The first code transition should occur for an analog value $1 / 2$ LSB above nominal negative full scale. The last transition should occur $11 / 2$ LSB below the nominal positive full scale. Gain error is the deviation of the actual difference between first and last code transitions and the ideal difference between first and last code transitions.

## POWER SUPPLY REJECTION

One of the effects of power supply variation on the performance of the device will be a change in gain error. The specification shows the maximum gain error deviation as the supplies are varied from their nominal values to their specified limits.

## SIGNAL-TO-NOISE PLUS DISTORTION (S/N+D) RATIO

$\mathrm{S} / \mathrm{N}+\mathrm{D}$ is the ratio of the rms value of the measured input signal to the rms sum of all other spectral components including harmonics but excluding dc . The value for $\mathrm{S} / \mathrm{N}+\mathrm{D}$ is expressed in decibels.

## EFFECTIVE NUMBER OF BITS (ENOB)

ENOB is calculated from the following expression:
$\mathrm{S} / \mathrm{N}+\mathrm{D}=6.02 \mathrm{~N}+1.76$, where N is equal to the effective number of bits.

## TOTAL HARMONIC DISTORTION (THD)

THD is the ratio of the rms sum of the first six harmonic components to the rms value of the measured input signal and is expressed as a percentage or in decibels.

## SPURIOUS FREE DYNAMIC RANGE

The peak spurious or peak harmonic component is the largest spectral component excluding the input signal and dc. This value is expressed in decibels relative to the rms value of a fullscale input signal.

## INTERMODULATION DISTORTION (IMD)

With inputs consisting of sine waves at two frequencies, fa and fb , any device with nonlinearities will create distortion products, of order ( $m+n$ ), at sum and difference frequencies of $m f a \pm n f b$, where $\mathrm{m}, \mathrm{n}=0,1,2,3 \ldots$ Intermodulation terms are those for which $m$ or $n$ is not equal to zero. For example, the second order terms are $(\mathrm{fa}+\mathrm{fb})$ and $(\mathrm{fa}-\mathrm{fb})$ and the third order terms are $(2 f a+f b),(2 f a-f b),(f a+2 f b)$ and $(f a-2 f b)$. The IMD products are expressed as the decibel ratio of the rms sum of the measured input signals to the rms sum of the distortion terms. The two signals are of equal amplitude and the peak value of their sums is -0.5 dB from full scale. The IMD products are normalized to a 0 dB input signal.

## DIFFERENTIAL GAIN

The percentage difference between the output amplitudes of a small high frequency sine wave at two stated levels of a low frequency signal on which it is superimposed.

## DIFFERENTIAL PHASE

The difference in the output phase of a small high frequency sine wave at two stated levels of a low frequency signal on which it is superimposed.

## TRANSIENT RESPONSE

The time required for the AD773A to achieve its rated accuracy after a full-scale step function is applied to its input.

## OVERVOLTAGE RECOVERY TIME

The time required for the ADC to recover to full accuracy after an analog input signal $150 \%$ of full scale is reduced to $50 \%$ of the full-scale value.

## APERTURE DELAY

The difference between the switch delay and the analog delay of the THA. This effective delay represents the point in time, relative to the falling edge of the CLOCK input, that the analog input is sampled.

## APERTURE JITTER

The variations in aperture delay for successive samples.

## PIPELINE DELAY (LATENCY)

The number of clock cycles between conversion initiation and the associated output data being made available. New output data is provided every clock cycle.

## FULL POWER BANDWIDTH

The input frequency at which the amplitude of the reconstructed fundamental is reduced by 3 dB for a full-scale input.

## AD773A—Dynamic Characteristics



Figure 2. $S / N+D$ vs. Input Frequency, $f_{C L K}=20 \mathrm{MSPS}$


Figure 3. CMR vs. Input Frequency, $f_{C L K}=20 \mathrm{MSPS}$


Figure 4. Harmonic Distortion vs. Input Frequency, $f_{C L K}=20$ MSPS: Full Power


Figure 5. Harmonic Distortion vs. Input Frequency, $f_{\text {CLK }}=20$ MSPS: Small Signal


Figure 6. Typical FFT Plot of AD773A, $f_{C L K}=20$ MSPS, $f_{I N}=1 \mathrm{MHz}$ at $1 \mathrm{Vp}-p$


Figure 7. Typical FFT Plot of AD773A, $f_{\text {CLK }}=20$ MSPS, $f_{\text {IN }}=9.9 \mathrm{MHz}$ at $1 \mathrm{Vp-p}$

## Theory of Operation

The AD773A uses a pipelined multistage architecture with a differential input, fast settling track-and-hold amplifier (THA). Traditionally, high speed ADCs have used parallel, or flash architectures. When compared to flash converters, multistage architectures reduce the power dissipation and die size by reducing the number of comparators. For example, the AD773A uses 48 comparators compared to 1023 comparators for a 10 -bit flash architecture.
The AD773A's main signal path transmits differential current mode signals. Low impedance current summing techniques are employed, increasing speed by reducing sensitivity to parasitic capacitances. Pipelining allows the stages to operate concurrently and maximizes system throughput.
The input THA is followed by three 4-bit conversion stages. At any given time, the first stage operates on the most recent sample, while the second stage operates on a signal dependent on the previous sample. This process continues throughout all three stages. The twelve digital bits provided by the three 4-bit stages are combined in the correction logic to produce a 10 -bit representation of the sampled analog input.
Pipeline delay, or latency, is four clock cycles. New output data is provided every clock cycle and is provided in both binary and twos complement format. The AD773A will flag an out-of-range condition when the analog input exceeds the specified analog input range.

## Applying the AD773A

## DRIVING THE AD773A INPUT

The AD773A may be driven in a single-ended or differential fashion. $\mathrm{V}_{\text {INA }}$ is the positive input, and $\mathrm{V}_{\text {INB }}$ is the negative input. In the single-ended configuration either $\mathrm{V}_{\text {INA }}$ or $\mathrm{V}_{\text {INB }}$ is connected to Analog Ground (AGND) while the other input is driven with a full-scale input of $\pm 500 \mathrm{mV}$ p-p. An inverted mode of operation can be achieved by simply interchanging the input connections.
Both inputs of the AD773A, $\mathrm{V}_{\text {INA }}$ and $\mathrm{V}_{\text {INB }}$, are high impedance and do not need to be driven by a low impedance source. Note, however, that as the source impedance increases, the input node becomes more susceptible to noise. The increased noise at the input will degrade performance. A 10 pF capacitor across $V_{\text {INA }}$ and $V_{\text {INB }}$ as shown in Figure 8 is recommended to bypass high frequency noise.


Figure 8. AD773A Single-Ended Input Connection

## INPUT CONDITIONING

In some cases, it may be appropriate to buffer the input source, add dc offset, or otherwise condition the input signal of the AD773A. Choosing an appropriate op amp will vary with system requirements and the desired level of performance. Some suggested op amps are the AD9617, AD842, and AD827.
Figure 9 shows a typical application where a unipolar signal is level shifted to the bipolar input range of the AD773A. Note that the reference used with the AD773A can also provide a noise-free voltage source to generate the dc offset.


Figure 9. Unipolar to Bipolar Input Connection

## DIFFERENTIAL INPUT CONNECTIONS

Operating the AD773A with fully differential inputs offers the advantage of rejecting common-mode signals present on both $\mathrm{V}_{\text {INA }}$ and $\mathrm{V}_{\text {INB }}$. The full-scale input range of $\mathrm{V}_{\text {INA }}$ and $\mathrm{V}_{\text {INB }}$ when driven differentially is $\pm 250 \mathrm{mV}$ p-p as shown in Table I.

Table I. AD773A's Maximum Differential Input Voltage

| $\mathbf{V}_{\text {INA }}$ | $\mathbf{V}_{\text {INB }}$ | $\mathbf{V}_{\text {INA }}-\mathbf{V}_{\text {INB }}$ |
| :--- | :--- | :--- |
| +250 mV | -250 mV | +500 mV |
| -250 mV | +250 mV | -500 mV |

In some applications it may be desirable to convert a singleended signal to a differential signal before being applied to the AD773A. Figure 10 shows a single-ended to differential video line driver capable of driving doubly terminated cables.

Figure 10. Single-Ended to Differential Connection


## REFERENCE INPUT

The AD773A's high impedance reference input allows direct connection with standard voltage references. Unlike the resistor ladder requirements of a flash converter the AD773A's single pin, high impedance input can be driven from one low cost, low power reference. The high impedance input allows multiple AD773A's to be driven from one reference thus minimizing drift errors.
Figure 11 shows the AD773A connected to the AD680. The AD680 is a single supply, low power, low cost 2.5 V reference with performance specifications ideally suited for the AD773A. The low pass filter minimizes the AD680's wideband noise. Other recommended 2.5 V references are the AD580 and REF43.


Figure 11. Recommended AD773A to AD680 Connection

## CLOCK INPUT

The AD773A's pipelined architecture operates on both the rising and falling edges of the clock input. A low jitter, symmetrical clock will provide the highest level of performance. The recommended logic family to drive the clock input is HC. The AD773A's minimum clock half cycle may necessitate the use of an external divide-by-two circuit as shown in Figure 12. Power dissipation will vary with input clock frequency as shown in Figure 13.


Figure 12. Divide-by-Two Clock Circuit


Figure 13. Power Dissipation vs. Sample Frequency

## EQUIVALENT ANALOG INPUT CIRCUIT

The AD773A equivalent analog input circuit is shown in Figure 14. The typical input bias current is $5 \mu \mathrm{~A}$, while input capacitance is typically 5 pF . In the single-ended input configuration one input is connected to AGND while the second input is driven to full scale $( \pm 500 \mathrm{mV})$. Under nominal conditions the collector of the input transistor is at +1.15 V . This allows signals to be offset by up to +0.65 V without significantly degrading performance. In the negative direction, the emitter of the input transistor should not drop below -1.25 V . Therefore, signals can be offset by -0.65 V without significant performance degradation. Figure 15 shows signal-to-noise ratio vs. commonmode input voltage.


Figure 14. Equivalent Analog Input Circuit


Figure 15. $S / N+D$ vs. Common-Mode Input Voltage, $f_{C L K}=20 \mathrm{MSPS}$

## EQUIVALENT REFERENCE INPUT CIRCUIT

The AD773A is designed to have a reference to analog input voltage ratio of $2.5: 1$. When the AD773A is configured for single-ended operation a 2.5 volt reference input establishes a full-scale analog input voltage of 1 V p-p $( \pm 500 \mathrm{mV}$ with respect to $\mathrm{V}_{\mathrm{INB}}$ ). Although the AD773A is specified and tested with $\mathrm{V}_{\mathrm{REF}}$ equal to 2.5 V and $\mathrm{V}_{\mathrm{IN}}$ equal to $\pm 500 \mathrm{mV}$ the reference input voltage and analog input voltages can be changed. To optimize the AD773A's performance the $2.5: 1$ ratio should be maintained. The simplified model of the AD773A's reference input circuit is shown in Figure 16.


Figure 16. Typical Reference Input Circuit
The 2.5 V external reference is applied across resistor R1 producing a current which in turn generates a voltage $\mathrm{V}_{\text {bias. }}$. Multiple reference currents are generated from $\mathrm{V}_{\text {BIAS }}$ and are used throughout the converter. R3 is used to cancel errors induced by the input bias current of the REFGND buffer. Figure 17 shows the SNR performance as the reference voltage is varied from its nominal value of 2.5 V . The input full-scale voltage is defined by the following equation,

$$
\text { Input Full-Scale Voltage }=\frac{\text { Reference Voltage }}{2.5}
$$

The power dissipation is modulated by variations in the reference voltage. Figure 18 shows the variation in power dissipation versus reference voltage.


Figure 17. $S / N+D$ vs. Reference Input Voltage, $f_{C L K}=20 \mathrm{MSPS}, f_{I N}=1 \mathrm{MHz}$


Figure 18. Power Dissipation vs. Reference Input Voltage, $f_{\text {CLOCK }}=20$ MSPS

## TRANSIENT RESPONSE

The fast settling input THA accurately converts full-scale input voltage swings in under one clock cycle. The THA's high impedance, fast slewing performance is critical in multiplexed or dc stepped (charge coupled devices, infrared detectors) systems. Figure 19 show the AD773A's settling performance with an input signal stepped from -500 mV to 0 V . As can be seen, the output code settles to its final value in under one clock cycle.


Figure 19. Typical AD773A Settling Time

## OUTPUT DATA FORMAT

The AD773A provides both MSB and $\overline{\text { MSB }}$ outputs, delivering positive true offset binary and twos complement output data. Table II shows the AD773A's output data format.

Table II. Output Data Format

| Analog Input | Digital Output |  |  |
| :--- | :--- | :--- | :--- |
|  | Offset | Twos <br> Complement | OTR |
| $\mathbf{V}_{\text {INA }}-\mathbf{V}_{\text {INB }}$ | Binary | 1111111111 | 0111111111 |
| $\geq 499.5 \mathrm{mV}$ | 1111111111 | 0111111111 | 0 |
| 499 mV | 1000000000 | 0000000000 | 0 |
| 0 mV | 0000000000 | 1000000000 | 0 |
| -500 mV | 0000000000 | 1000000000 | 1 |
| -500.5 mV | 0 |  |  |

## OUT OF RANGE

An out-of-range condition exists when the analog input voltage is beyond the input range ( $\pm 500 \mathrm{mV}$ ) of the converter. [Note the AD773A has a 4 clock cycle latency.] OTR (Pin 20) is set low when the analog input voltage is within the analog input range. OTR is set HIGH and will remain HIGH when the ana$\log$ input voltage exceeds the input range by $1 / 2$ LSB from the center of the $\pm$ full-scale output codes. OTR will remain HIGH until the analog input is within the input range. Note that if the input is driven beyond +1.5 V , the digital outputs may not stay at +FS, but may actually fold back to midscale. By logical ANDing OTR with the MSB and its complement, overrange high or underrange low conditions can be detected. Table III is a truth table for the over/under range circuit in Figure 20. Systems requiring programmable gain conditioning prior to the AD773A can immediately detect an out of range condition, thus eliminating gain selection iterations.


Figure 20. Overrange or Underrange Logic

Table III. Out-of-Range Truth Table

| OTR | MSB | ANALOG INPUT IS |
| :--- | :--- | :--- |
| 0 | 0 | In Range |
| 0 | 1 | In Range |
| 1 | 0 | Underrange |
| 1 | 1 | Overrange |

## GROUNDING AND LAYOUT RULES

As is the case for any high performance device, proper grounding and layout techniques are essential in achieving optimal performance. (Note-Figures 22-26 are not to scale.) The analog and digital grounds on the AD773A have been separated to optimize the management of return currents in a system. It is recommended that a 4-layer printed circuit board (PCB) which employs ground planes and power planes be used with the AD773A. The use of ground and power planes offers distinct advantages:

1. The minimization of the loop area encompassed by a signal and its return path.
2. The minimization of the impedance associated with ground and power paths.
3. The inherent distributed capacitor formed by the power plane, PCB insulation, and ground plane.
These characteristics result in both a reduction of electromagnetic interference (EMI) and an overall improvement in performance.
It is important to design a layout which prevents noise from coupling onto the input signal. The wide input bandwidth of the AD773A permits noise outside the desired Nyquist bandwidth to be sampled along with the desired signal. This can result in a higher overall level of spurious noise in the digitized output. Digital signals should not be run in parallel with the circuitry. It is also suggested that the traces associated with $\mathrm{V}_{\text {INA }}$ and $\mathrm{V}_{\text {INB }}$ be the same length.
Separate analog and digital grounds should be joined together directly under the AD773A (see Figure 24). A solid ground plane under the AD773A is also acceptable if care is taken in the management of the power and ground return currents. A general "rule-of-thumb" for mixed signal layouts dictates that the return currents from digital circuitry should not pass through critical analog circuitry.

## POWER SUPPLY DECOUPLING

The analog and digital supplies of the AD773A have been separated to prevent the typically large transients associated with digital circuitry from coupling into the analog supplies ( $\mathrm{AV}_{\mathrm{DD}}$, $\mathrm{AV}_{\mathrm{Ss}}$ ). Each analog power supply pin should be decoupled with a $0.1 \mu \mathrm{~F}$ capacitor located as close to the pin as possible. Additionally, $0.22 \mu \mathrm{~F}$ capacitors for the $\mathrm{DRV}_{\mathrm{DD}}$ and $\mathrm{DV}_{\mathrm{DD}}$ supplies are required to adequately suppress high frequency noise. For optimal performance, surface-mount capacitors are recommended. The inductance associated with the leads of throughhole ceramic capacitors typically render them ineffective at higher frequencies. A complete system will also incorporate tantalum capacitors in the $10-100 \mu \mathrm{~F}$ range to decouple low frequency noise and ferrite beads to limit high frequency noise.
The digital supplies have also been separated into $\mathrm{DRV}_{\mathrm{DD}}$ and $\mathrm{DV}_{\mathrm{DD}}$. The $\mathrm{DRV}_{\mathrm{DD}}$ pins provide power for the digital output drivers of the AD773A and are likely to contain high energy transients. Pin 22 should be decoupled directly to Pin 21 (DRGND) and Pin 7 should be decoupled directly to Pin 8 (DRGND) to minimize the length of the return path for these transients. A single +5 V supply is all that is required for $D R V_{D D}$ and $D V_{D D}$, but decoupling $D V_{D D}$ with an $R C$ filter network is suggested (see Figure 21).


Figure 21. AD773A Evaluation Board Schematic

Table IV. Components List

| Reference Designator | Description | Quantity |
| :--- | :--- | :--- |
| R2, R4 | Resistor, $1 \%, 49.9 \Omega$ | 2 |
| R5, R6, R11-R22 | Resistor, $5 \%, 22 \Omega$ | 14 |
| R7, R8 | Resistor $5 \%, 39 \Omega$ | 2 |
| R9 | Resistor, $5 \%, 75 \Omega$ | 1 |
| P10 | Resistor, $5 \%, 560 \Omega$ | 1 |
| C1, C3-C8, C11, C14, C17-C21 | Chip Cap, $0.1 \mu \mathrm{~F}$ | 14 |
| C2 | Capacitor, Tantalum, 10 $\mu \mathrm{F}$ | 1 |
| C9, C12, C15 | Chip Cap, 0.01 $\mu \mathrm{F}$ |  |
| C10, C13, C16 | Capacitor, Tantalum, 22 $\mu \mathrm{F}$ | 3 |
| U1 | AD773A | 1 |
| U2 | ADV7122 | 1 |
| U3 | AD680 | 1 |
| U4 | AD589 | 1 |
| U5 | 74AS04 | 1 |
| FB1-FB3 | Ferrite Bead | 3 |



Figure 22. Component Side PCB Layout


Figure 23. Solder Side PCB Layout


Figure 24. Ground Layer PCB Layout


Figure 25. Power Layer PCB Layout


Figure 26. Silkscreen Layer PCB Layout

FEATURES
CMOS 8-Bit 20 MSPS Sampling A/D Converter
Low Power Dissipation: $\mathbf{6 0} \mathbf{~ m W}$
+5 V Single Supply Operation
Differential Nonlinearity: 0.3 LSB
Differential Gain: 1\%
Differential Phase: 0.5 Degrees
Three-State Outputs
On-Chip Reference Bias Resistors
Adjustable Reference Input
Video Industry Standard Pinout
Small Packages:
24-Pin, $\mathbf{3 0 0}$ Mil SOIC Surface Mount
24-Pin, 400 Mil Plastic DIP

## PRODUCT DESCRIPTION

The AD775 is a CMOS, low power, 8 -bit, 20 Msps sampling analog-to-digital converter (ADC). The AD775 features a builtin sampling function and on-chip reference bias resistors to provide a complete 8 -bit ADC solution. The AD775 utilizes a pipelined/ping pong two-step flash architecture to provide high sampling rates (up to 35 MHz ) while maintaining very low power consumption ( 60 mW ).
Its combination of excellent DNL, fast sampling rate, low differential gain and phase errors, extremely low power dissipation, and single +5 V supply operation make it ideally suited for a variety of video and image acquisition applications, including portable equipment. The AD775's reference ladder may be connected in a variety of configurations to accommodate different input ranges. The low input capacitance ( 11 pF typical) provides an easy-to-drive input load compared to conventional flash converters.

The AD775 is offered in both 300 mil SOIC and 400 mil DIP plastic packages, and is designed to operate over an extended commercial temperature range ( $-20^{\circ} \mathrm{C}$ to $+75^{\circ} \mathrm{C}$ ).

FUNCTIONAL BLOCK DIAGRAM


## PRODUCT HIGHLIGHTS

Low Power: The AD775 has a typical supply current of 12 mA , for a power consumption of 60 mW . Reference ladder current is also low: 6.6 mA typical, minimizing the reference power consumption.

Complete Solution: The AD775's switched capacitor design features an inherent sample/hold function: no external SHA is required. On-chip reference bias resistors are included to allow a supply-based reference to be generated without any external resistors.
Excellent Differential Nonlinearity: The AD775 features a typical DNL of 0.3 LSBs, with a maximum limit of 0.5 LSBs. No missing codes is guaranteed.
Single +5 V Supply Operation: The AD775 is designed to operate on a single +5 V supply, and the reference ladder may be configured to accommodate analog inputs inclusive of ground.
Low Input Capacitance: The 11 pF input capacitance of the AD775 can significantly decrease the cost and complexity of input driving circuitry, compared with conventional 8 -bit flash ADCs.

$\left.\begin{array}{l|ccc|c}\hline \text { Parameter } & \text { Min } & \text { AD775J } \\ \text { Typ }\end{array}\right)$

## NOTES

${ }^{1}$ NSTC 40 IRE modulation ramp, CLOCK $=14.3 \mathrm{Msps}$.
${ }^{2} \mathrm{f}_{\mathrm{IN}}$ amplitude $=-0.3 \mathrm{~dB}$ full scale.
Specifications subject to change without notice. See Definition of Specifications for additional information.
 CLOCK $=20 \mathrm{MHz}$ unless otherwise noted)
$\left.\begin{array}{l|l|l|ll|l}\hline \text { Parameter } & \text { Symbol } & \mathbf{D V}_{\text {DD }} & \text { Min } & \begin{array}{l}\text { AD775J } \\ \text { Typ }\end{array} & \text { Max }\end{array}\right)$ Units

TIMING SPECIFICATIONS

|  | Symbol | Min | Typ | Max | Units |
| :--- | :--- | :--- | :--- | :--- | :--- |
| Maximum Conversion Rate |  | 20 | 35 |  | MHz |
| Clock Period | $\mathrm{t}_{\mathrm{C}}$ | 50 |  | ns |  |
| Clock High | $\mathrm{t}_{\mathrm{CH}}$ | 25 |  | ns |  |
| Clock Low | $\mathrm{t}_{\mathrm{CL}}$ | 25 | 18 | ns |  |
| Output Delay <br> Pipeline Delay (Latency) | $\mathrm{t}_{\mathrm{OD}}$ |  |  |  |  |
| Sampling Delay |  |  | 2.5 | Clock Cycles |  |
| Aperture Jitter | $\mathrm{t}_{\mathrm{DS}}$ |  | 30 | ns |  |

[^15]

Figure 1. AD775 Timing Diagram

PIN DESCRIPTION

| Pin No. | Symbol | Type | Name and Function |
| :---: | :---: | :---: | :---: |
| 1 | $\overline{\mathrm{OE}}$ | DI | $\overline{\mathrm{OE}}=$ Low $\overline{\mathrm{OE}}=$ High <br> Normal Operating Mode. High Impedance Outputs. |
| 2, 24 | DV ${ }_{\text {ss }}$ | P | Digital Ground. Note: $\mathrm{DV}_{\text {SS }}$ and $\mathrm{AV}_{\text {sS }}$ pins should share a common ground plane on the circuit board. |
| 3 | D0 (LSB) | DO | Least Significant Bit, Data Bit 0. |
| 4-9 | D1-D6 | DO | Data Bits 1 Through 6. |
| 10 | D7 (MSB) | DO | Most Significant Bit, Data Bit 7. |
| 11, 13 | DV ${ }_{\text {DD }}$ | P | +5 V Digital Supply. Note: $\mathrm{DV}_{\mathrm{DD}}$ and $\mathrm{AV}_{\mathrm{DD}}$ pins should share a common supply on the circuit board. |
| 12 | CLK | DI | Clock Input. |
| 16 | $\mathrm{V}_{\text {RTS }}$ | AI | Reference Top Bias. Short to $\mathrm{V}_{\text {RT }}$ for Self Bias. |
| 17 | $\mathrm{V}_{\text {RT }}$ | AI | Reference Ladder Top. |
| 23 | $\mathrm{V}_{\text {RB }}$ | AI | Reference Ladder Bottom. |
| 22 | $\mathrm{V}_{\text {RBS }}$ | AI | Reference Bottom Bias. Short to $\mathrm{V}_{\mathrm{RB}}$ for Self Bias. |
| 14, 15, 18 | $\mathrm{AV}_{\text {DD }}$ | P | +5 V Analog Supply. Note: $\mathrm{DV}_{\mathrm{DD}}$ and $\mathrm{AV}_{\mathrm{DD}}$ pins should share a common supply within 0.5 inches of the AD775. |
| 19 | $\mathrm{V}_{\text {IN }}$ | AI | Analog Input. Input Span $=\mathrm{V}_{\mathrm{RT}}-\mathrm{V}_{\mathrm{RB}}$. |
| 20, 21 | $\mathrm{AV}_{\text {ss }}$ | P | Analog Ground. Note: $\mathrm{DV}_{\text {SS }}$ and $A V_{\text {SS }}$ pins should share a common ground within 0.5 inches of the AD775. |

## NOTE

Type: $\mathrm{AI}=$ Analog Input; $\mathrm{DI}=$ Digital Input; $\mathrm{DO}=$ Digital Output; $\mathrm{P}=$ Power.


## MAXIMUM RATINGS*

Supply Voltage (AV ${ }_{\text {DD }}$, DV $_{\text {DD }}$ ) . . . . . . . . . . . . . . . . . 7 V
Supply Difference ( $\mathrm{AV}_{\mathrm{DD}}-\mathrm{DV}_{\mathrm{DD}}$ ) . . . . . . . . . . . . . . . 0 V
Ground Difference ( $\mathrm{AV}_{\mathrm{Ss}}-\mathrm{DV}_{\text {ss }}$ ) . . . . . . . . . . . . . . . . 0 V
Reference Voltage ( $\mathrm{V}_{\mathrm{RT}}, \mathrm{V}_{\mathrm{RB}}$ ) . . . . . . . . . . . . . $\mathrm{V}_{\mathrm{DD}}$ to $\mathrm{V}_{\mathrm{SS}}$
Analog Input Voltage ( $\mathrm{V}_{\mathrm{IN}}$ ) . . . . . . . . . . . . . . $\mathrm{V}_{\mathrm{DD}}$ to $\mathrm{V}_{\text {Ss }}$
Digital Input Voltage (CLK) . . . . . . . . . . . . . . . $V_{\text {DD }}$ to $\mathrm{V}_{\text {ss }}$
Digital Output Voltage $\left(\mathrm{V}_{\mathrm{OH}}, \mathrm{V}_{\mathrm{OL}}\right) \ldots \ldots \mathrm{V}_{\mathrm{DD}}$ to $\mathrm{V}_{\mathrm{Ss}}$
Storage Temperature . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD775JN | $-20^{\circ} \mathrm{C}$ to $+75^{\circ} \mathrm{C}$ | 24-Pin 400 Mil Plastic DIP | N-24B |
| AD775JR | $-20^{\circ} \mathrm{C}$ to $+75^{\circ} \mathrm{C}$ | 24-Pin 300 Mil SOIC | R-24A |

*For outline information see Package Information section.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD775 features ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


Figure 2. $S /(N+D)$ vs. Input Frequency at 20 MSPS Clock Rate $\left(V_{I N}=-0.3 d B\right)$


Figure 3. Typical FFT at 1 MHz Input, 20 MSPS Clock Rate ( $V_{I N}=-0.5 \mathrm{~dB}$ )


Figure 4. Typical Differential Nonlinearity (DNL)


Figure 5. THD vs. Input Frequency at 20 MSPS Clock Rate $\left(V_{I N}=-0.3 d \dot{B}\right)$


Figure 6. Typical FFT at 5 MHz Input, 20 MSPS Clock Rate $\left(V_{I N}=-0.5 d B\right)$


Figure 7. Typical Integral Nonlinearity (INL)

## DEFINITIONS OF SPECIFICATIONS <br> Integral Nónlinearity (INL)

Integral nonlinearity refers to the deviation of each individual code from a line drawn from "zero" through "full scale." The point used as "zero" occurs $1 / 2$ LSB before the first code transition. "Full scale" is defined as a level $11 / 2$ LSB beyond the last code transition. The deviation is measured from the center of each particular code to the true straight line.

## Differential Nonlinearity (DNL, No Missing Codes)

An ideal ADC exhibits code transitions that are exactly 1 LSB apart. DNL is the deviation from this ideal value. It is often specified in terms of the resolution for which no missing codes (NMC) is guaranteed.

## Offset Error

The first code transition should occur at a level $1 / 2$ LSB above nominal negative full scale. Offset referred to the Bottom of Ladder $\mathrm{V}_{\mathrm{RB}}$ is defined as the deviation from this ideal. The last code transition should occur $11 / 2$ LSB below the nominal positive full scale. Offset referred to the Top of Ladder $\mathrm{V}_{\mathrm{RT}}$ is defined as the deviation from this ideal.

## Differential Gain

The percentage difference between the output amplitudes of a small high frequency sine wave at two stated levels of a low frequency signal on which it is superimposed.

## Differential Phase

The difference in the output phase of a small high frequency sine wave at two stated levels of a low frequency signal on which it is superimposed.
Pipeline Delay (Latency)
The number of clock cycles between conversion initiation and the associated output data being made available. New output data is provided every clock cycle.
Signal-to-Noise Plus Distortion Ratio (S/N+D)
$\mathrm{S} / \mathrm{N}+\mathrm{D}$ is the ratio of the rms value of the measured input signal to the rms sum of all other spectral components including harmonics but excluding dc. The value for $\mathrm{S} / \mathrm{N}+\mathrm{D}$ is expressed in decibels.

## Total Harmonic Distortion (THD)

THD is the ratio of the rms sum of the first six harmonic components to the rms value of the measured input signal and is expressed as a percentage or in decibels.

## THEORY OF OPERATION

The AD775 uses a pipelined two-step (subranging) flash architecture to achieve significantly lower power and lower input capacitance than conventional full flash converters while still maintaining high throughput. The analog input is sampled by the switched capacitor comparators on the falling edge of the input clock: no external sample and hold is required. The coarse comparators determine the top four bits (MSBs), and select the appropriate reference ladder taps for the fine comparators. With the next falling edge of the clock, the fine comparators determine the bottom four bits (LSBs). Since the LSB comparators require a full clock cycle between their sampling instant and their decision, the converter alternates between two sets of fine comparators in a "ping-pong" fashion. This multiplexing allows a new input sample to be taken on every falling clock edge, thereby providing 20 Msps operation. The data is accumulated in the correction logic and output through a three-state output latch on the rising edge of the clock. The latency between input sampling and the corresponding converted output is 2.5 clock cycles.
All three comparator banks utilize the same resistive ladder for their reference input. The analog input range is determined by the voltages applied to the bottom and top of the ladder, and the AD775 can digitize inputs down to 0 V using a single supply. On-chip application resistors are provided to allow the ladder to be conveniently biased by the supply voltage.
The AD775 uses switched capacitor auto-zeroing techniques to cancel the comparators' offsets and achieve excellent differential nonlinearity performance: typically $\pm 0.3$ LSB. The integral nonlinearity is determined by the linearity of the reference ladder and is typically +0.5 LSB.

## APPLYING THE AD775

## REFERENCE INPUT

The AD775 features a resistive reference ladder similar to that found in most conventional flash converters. The analog input range of the converter falls between the top $\left(\mathrm{V}_{\mathrm{RT}}\right)$ and bottom $\left(\mathrm{V}_{\mathrm{RB}}\right)$ voltages of this ladder. The nominal resistance of the ladder is 300 ohms, though this may vary from 230 ohms to 450 ohms. The minimum recommended voltage for $\mathrm{V}_{\mathrm{RB}}$ is 0 V ; the linearity performance of the converter may deteriorate for input spans $\left(\mathrm{V}_{\mathrm{RB}}-\mathrm{V}_{\mathrm{RB}}\right)$ below 1.8 V . While 2.8 V is the recommended maximum ladder top voltage ( $\mathrm{V}_{\mathrm{RT}}$ ), the top of the ladder may be as high as the positive supply voltage ( $\mathrm{AV}_{\mathrm{DD}}$ ) with minimal linearity degradation.


Figure 8. Reference Configuration: 0.64 V to 2.73 V
To simplify biasing of the AD775, on-chip reference bias resistors are provided on Pins 16 and 22. The two recommended configurations for these resistors are shown in Figures 8 and 9.

In the topology shown in Figure 8, the top of the ladder ( $\mathrm{V}_{\mathrm{RT}}$ ) is shorted to the top bias resistor ( $\mathrm{V}_{\mathrm{RTS}}$ ) (Pin 17 shorted to Pin 16), while the bottom of the ladder $\left(\mathrm{V}_{\mathrm{RB}}\right)$ is shorted to the bottom bias resistor ( $\mathrm{V}_{\mathrm{RBS}}$ ) (Pin 23 shorted to Pin 22). This creates a resistive path (nominally 725 ohms) between $A V_{D D}$ and $A V_{\text {SS }}$. For nominal supply voltages ( 5 V and 0 V respectively), this creates an input range of 0.64 V to 2.73 V .
Both top and bottom of the reference ladder should be decoupled, preferably with a chip capacitor to ground to minimize reference noise.
The topology shown in Figure 9 provides a ground-inclusive input range. The bottom of the ladder $\left(\mathrm{V}_{\mathrm{RB}}\right)$ is shorted to $\mathrm{AV} \mathrm{VS}_{\text {s }}$. $(0 \mathrm{~V})$, while the top of the ladder $\left(\mathrm{V}_{\mathrm{R} \cdot \mathrm{r}}\right)$ is connected to the on-board bias resistor ( $\mathrm{V}_{\mathrm{RTS}}$ ). This provides a nominal input range of 0 V to +2.4 V for $\mathrm{AV}_{\mathrm{DD}}$ of 5 V . The $\mathrm{V}_{\mathrm{RBS}}$ pin may be left floating, or shorted to $\mathrm{AV}_{\mathrm{ss}}$.


Figure 9. Reference Configuration: 0 V to +2.4 V
More elaborate topologies can be used for those wishing to provide an input span based on an external reference voltage. The circuit in Figure 10 uses the AD780 2.5 V reference to drive the top of the ladder $\left(\mathrm{V}_{\mathrm{RT}}\right)$, with the bottom $\left(\mathrm{V}_{\mathrm{RB}}\right)$ of the ladder grounded to provide an input span of 0 V to +2.5 V . This is modified in Figure 11 to shift the 2.5 V span up 700 mV .


Figure 10. Reference Configuration: 0 V to 2.5 V
The AD775 can accommodate dynamic changes in the reference voltage for gain or offset adjustment. However, conversions that are in progress, including those in the converter pipeline, while the reference voltages are changing will be invalid.


Figure 11. Reference Configuration: 0.7 V to 3.2 V

## ANALOG INPUT

The impedance looking into the analog input is essentially capacitive, as shown in the equivalent circuit of Figure 12, typically totalling around 11 pF . A portion of this capacitance is parasitic; the remainder is part of the switched capacitor structure of the comparator arrays. The switches close on the rising edge of the clock, acquire the input voltage, and open on the clock's falling edge (the sampling instant). The charge that must be moved onto the capacitors during acquisition will be a function of the converter's previous two samples, but there should be no sample-to-sample crosstalk so long as ample driving impedance and acquisition time are provided.


Figure 12. Equivalent Analog Input Circuit $\left(V_{I N}\right)$
For example, to ensure accurate acquisition (to $1 / 4$ bit accuracy) of a full-scale input step in less than 20 ns , a source impedance of less than 100 ohms is recommended. Figure 13 shows one option of input buffer circuitry using the AD817. The AD817 acts as both an inverting buffer and level shifting circuit. In order to level shift the ground-based input signal to the dc level required by the input of the AD775, the supply voltage is resistively divided to produce the appropriate voltage at the noninverting input of the AD817. For most applications, the AD817 provides a low cost, high performance level shifter. The AD811 is recommended for systems which require faster settling times.


Figure 13. Level Shifting Input Buffer
The analog input range is set by the voltage at the top and bottom of the reference ladder. In general, the larger the span ( $\mathrm{V}_{\mathrm{RT}}-\mathrm{V}_{\mathrm{RB}}$ ), the better the differential nonlinearity (DNL) of the converter; a 1.8 V span is suggested as a minimum to realize good linearity performance. As the input voltage exceeds 2.8 V (for $\mathrm{AV}_{\mathrm{DD}}=4.75 \mathrm{~V}$ ), the input circuitry may start to slightly degrade the acquisition performance.

## CLOCK INPUT

The AD775's internal control circuitry makes use of both clock edges to generate on-chip timing signals. To ensure proper settling and linearity performance, both $\mathrm{t}_{\mathrm{CH}}$ and $\mathrm{t}_{\mathrm{CL}}$ times should be 25 ns or greater. For sampling frequencies at or near 20 Msps , a $50 \%$ duty cycle clock is recommended. For slower sampling applications, the AD775 can accommodate a wider range of duty cycles, provided each clock phase is as least 25 ns .
Under certain conditions, the AD775 can be operated at sampling rates above 20 Msps . Figure 14 shows the signal-to-noise plus distortion ( $\mathrm{S} /(\mathrm{N}+\mathrm{D})$ ) performance of a typical AD775 versus clock frequency. It is extremely important to note that the maximum clock rate will be a strong function of both temperature and supply voltage. In general, the part slows down with increasing temperature and decreasing supply voltage.


Figure 14. $S(N+D)$ vs. Clock Frequency (Temperature $=$ $+25^{\circ} \mathrm{C}$ )

A significant portion of the AD775's power dissipation is proportional to the clock frequency: Figure 15 illustrates this tradeoff for a typical part.


Figure 15. Power Dissipation vs. Clock Frequency
In applications sensitive to aperture jitter, the clock signal should have a fall time of less than 3 ns . High speed CMOS logic families (HC/HCT) are recommended for their symmetrical swing and fast rise/fall times. Care should be taken to minimize the fanout and capacitive loading of the clock input line.

## DIGITAL INPUTS AND OUTPUTS

The AD775's digital interface uses standard CMOS, with logic thresholds roughly midway between the supplies ( $\mathrm{DV}_{\mathrm{Ss}}$, $\mathrm{DV}_{\mathrm{DD}}$ ). The digital output is presented in straight binary format, with full scale (1111 1111) corresponding to $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{RT}}$, and zero ( 00000000 ) corresponding to $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{RB}}$. Excessive capacitive loading of the digital output lines will increase the dynamic power dissipation as well as the on-chip digital noise. Logic fanout and parasitic capacitance on these lines should be minimized for optimum noise performance.
The data output lines may be placed in a high output impedance state by bringing $\overline{\mathrm{OE}}$ (Pin 1) to a logic high. Figure 16 indicates typical timing for access and float delay times ( $\mathrm{t}_{\mathrm{HL}}$ and $\mathrm{t}_{\mathrm{DD}}$ respectively). Note that even when the outputs are in a high impedance state, activity on the digital bus can couple back to the sensitive analog portions of the AD775 and corrupt conversions in progress.


Figure 16. High Impedance Output Timing

FEATURES
Monolithic 16-Bit Sigma-Delta ADC
Third-Order Noise Shaping
96 dB Dynamic Range
90 dB SNR
$16-$ Bit 100 kHz Output from FIR Filter
12-Bit 400 kHz Output from Comb Filter No Missing Codes
$<0.001$ dB In-Band Ripple

## APPLICATIONS

Digital Audio Disk/Tape
Voice Bandwidth Communications
ADC Support for ADSP-21XX
High Accuracy Measurement Systems

## PRODUCT DESCRIPTION

The AD776 is a 16-bit sigma-delta oversampled ADC, incorporating a 1 -bit third-order modulator and digital decimation filter. An on-chip voltage reference circuit is also included.
The AD776 does not generally require the use of sample-hold circuits or complex antialiasing filters as a result of its sigmadelta architecture. The output is available both before and after the final Finite Impulse Response (FIR) decimation filter. This provides the flexibility of optimizing conversion speed or dynamic range: $12-\mathrm{bit} / 400 \mathrm{kHz}$ (from the comb filter) or 16-bit/ 100 kHz (from the FIR filter). The serial port provides easy interface with a variety of standard processors including the ADSP-21XX.

The AD776 is specified for ac (or "dynamic") parameters such as SNR, THD and IMD which are important in signal processing and audio applications. Third order noise shaping is employed using 64 times oversampling to provide 90 dB SNR and -100 dB peak spurious component for signal bandwidths up to 45 kHz .

The AD776 operates from a single +5 V supply and typically consumes 350 mW during conversion. The device is packaged in 20-pin ceramic DIP (cerdip) and is offered in an industrial temperature grade $\left(-40^{\circ} \mathrm{C}\right.$ to $\left.+85^{\circ} \mathrm{C}\right)$.

FUNCTIONAL BLOCK DIAGRAM


## PRODUCT HIGHLIGHTS

1. Analog Front End. The analog input is differential providing increased signal swing, increased power supply rejection ratio, and reduced sensitivity to clock jitter. Since the input signal is oversampled by a factor of 64 , a complex antialiasing filter is not needed.
2. Flexible Digital Interface. The AD776 has three output pins for the serial interface: 1) serial data out (DOUT), 2) frame sync out (FSO), and 3) serial clock out (DOUT CLOCK). The serial port can interface with general purpose DSPs such as the ADSP-21XX, TMS320XX, and DSP56001/2 without additional "glue" logic.
3. Inherently Self-Sampling. The AD776 needs no external sample-and-hold amplifier to capture and freeze the analog input while the conversion takes place.
4. Speed/Performance Options. In addition to the standard 16-bit resolution at 100 kHz , the output of the comb filter can be accessed to provide 12 -bit resolution at 400 kHz .

## AD776 - SPECIFICATIONS

( $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }} ; \mathrm{AV}_{D D}, \mathrm{DV}_{D D}=+5 \mathrm{~V}$, FIR filter output mode unless otherwise noted)

| Parameter | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: |
| RESOLUTION | 16 |  |  | Bits |
| TEMPERATURE RANGE | -40 |  | +85 | ${ }^{\circ} \mathrm{C}$ |
| TOTAL HARMONIC DISTORTION (THD) ${ }^{1,2,3}$ | $\begin{aligned} & \hline-80 \\ & 0.01 \\ & \hline \end{aligned}$ | $\begin{aligned} & \hline-83 \\ & 0.003 \end{aligned}$ |  | $\begin{aligned} & \hline \mathrm{dB} \\ & \% \end{aligned}$ |
| $\begin{aligned} & \text { SIGNAL-TO-NOISE RATIO }(\mathrm{SNR})^{1,2}, \mathrm{f}_{\mathrm{S}}=48 \mathrm{ksps} \\ & \text { Signal to Noise Ratio }(\mathrm{SNR})^{1,2,2}, \mathrm{f}_{\mathrm{S}}=100 \mathrm{ksps} \\ & \text { Comb Filter Mode, CLKIN }=12.8 \mathrm{MHz} \\ & \hline \end{aligned}$ | 88 | $\begin{aligned} & 90 \\ & 86 \\ & 72 \\ & \hline \end{aligned}$ |  | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \end{aligned}$ |
| PEAK SPURIOUS OR PEAK HARMONIC COMPONENT |  | -100 |  | dB |
| INTERMODULATION DISTORTION (IMD) ${ }^{4}$ <br> 2nd Order Products <br> 3rd Order Products |  | $\begin{aligned} & -102 \\ & -98 \end{aligned}$ |  | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \end{aligned}$ |
| VOLTAGE REFERENCE OUTPUT ( $\mathrm{V}_{\text {REF }}$ ) | $\left(\mathrm{AV}_{\mathrm{DD}} \times 0.4\right)-4 \%$ | $\mathrm{AV}_{\mathrm{DD}} \times 0.4 \mathrm{~V}$ | $\left(\mathrm{AV}_{\mathrm{DD}} \times 0.4\right)+4 \%$ | V |
| MAXIMUM ANALOG INPUT RANGE ${ }^{\text {s }}$ |  | $2 \times \mathrm{V}_{\text {REF }}-0.5$ |  | V p-p |
| MAXIMUM INPUT SIGNAL ${ }^{6}$ |  | $\pm 0.5 \mathrm{~V}_{\text {REF }}$ |  | Vp-p |
| DC ACCURACY ${ }^{1}$ <br> Differential Nonlinearity <br> INL <br> Gain Error <br> Midscale Error |  | $\begin{aligned} & \pm 0.5 \\ & 2 \\ & 1.0 \\ & 0.5 \\ & \hline \end{aligned}$ |  | $\begin{aligned} & \text { LSB } \\ & \text { LSB } \\ & \% \\ & \% \end{aligned}$ |
| DIGITAL FILTER CHARACTERISTICS <br> Passband Ripple <br> Stopband Attenuation |  | $\begin{aligned} & 0.001 \\ & -96 \\ & \hline \end{aligned}$ |  | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \end{aligned}$ |
| POWER SUPPLY REQUIREMENTS ${ }^{7}$ <br> Analog Supply Voltage ( $\mathrm{AV} \mathrm{VD}_{\mathrm{DD}}$ ) <br> Digital Supply Voltage ( $\mathrm{DV}_{\mathrm{DD}}$ ) <br> Analog Supply Current <br> Digital Supply Current <br> Power Consumption ${ }^{8}$ <br> Power Supply Rejection ${ }^{9}$ | 4.5 4.5 | $\begin{aligned} & 5.0 \\ & 20 \\ & 20 \\ & 300 \\ & 70 \end{aligned}$ | $\begin{aligned} & 5.5 \\ & \mathrm{AV}_{\mathrm{DD}} \\ & 400 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~mA} \\ & \mathrm{~mA} \\ & \mathrm{~mW} \\ & \mathrm{~dB} \end{aligned}$ |

## DIGITAL SPECIFICATIONS

| Parameter |  | Test Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| LOGIC INPUTS |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{IH}}$ | High Level Input Voltage |  | $2: 0$ |  | $\mathrm{V}_{\mathrm{DD}}$ | V |
| $\mathrm{V}_{\text {IL }}$ | Low Level Input Voltage |  | -0.5 |  | 0.8 | V |
| $\mathrm{I}_{\mathrm{IH}}$ | High Level Input Current | $\mathrm{V}_{\mathrm{IH}}=\mathrm{V}_{\mathrm{DD}}$ |  | 1 |  | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{IL}}$ | Low Level Input Current | $\mathrm{V}_{\mathrm{IL}}=0 \mathrm{~V}$ |  | 1 |  | $\mu \mathrm{A}$ |
| $\mathrm{C}_{\text {IN }}$ | Input Capacitance |  |  | 10 |  | pF |
| $\mathrm{I}_{\mathrm{Z}}$ | Hi-Z Input Current for SDO |  |  |  | 10 | $\mu \mathrm{A}$ |
| LOGIC OUTPUTS |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{OH}}$ | High Level Output Voltage | $\mathrm{I}_{\mathrm{OH}}=0.4 \mathrm{~mA}$ | 2.4 | . |  | V |
| $\mathrm{V}_{\mathrm{OL}}$ | Low Level Output Voltage | $\mathrm{I}_{\mathrm{OL}}=2.0 \mathrm{~mA}$ |  |  | 0.5 | V |

## NOTES

${ }^{1} \mathrm{At}+25^{\circ} \mathrm{C}$.
${ }^{2}$ Analog Input $=1.2 \mathrm{~V}$ rms (f $10 \mathrm{kHz}, \mathrm{V}_{\text {COMMON MODe }}=2.5 \mathrm{~V}$, CLKIN $=6.4 \mathrm{MHz}$.
${ }^{3}$ THD performance can be improved, depending upon the application, by making slight adjustments to the dc common mode voltage at the analog inputs.
${ }^{4} \mathrm{IMD}$ measured at $\mathrm{f}_{\mathrm{s}}=48 \mathrm{kHz}$ and using 61.6 Hz and 986.4 Hz as the input tones (sum of the two peaks added to be -3 dB FS ).
${ }^{5}$ Applied differentially between AIN + and AIN-.
${ }^{6}$ The input signal may be centered at any choice of dc offset voltage as long as peak values are bounded by the Maximum Analog Input Range value. Performance may be improved by reducing the maximum input signal by 3 dB . For nominal operation, 2.5 V dc offset is recommended.
${ }^{7}$ The AD776 may be operated from a single +5 V supply.
${ }^{8} \mathrm{AV}_{\mathrm{DD}}, \mathrm{DV}_{\mathrm{DD}}=5.5 \mathrm{~V} ; \mathrm{f}=12.8 \mathrm{MHz} ; \mathrm{T}_{\mathrm{A}}=+85^{\circ} \mathrm{C}$.
${ }^{9}$ With external voltage reference.
Specifications subject to change without notice.

## TIMING CHARACTERISTICS ${ }_{\left(A v_{00}\right.}$ ov $\mathrm{vvo}_{00}=+5 \mathrm{v} \pm 10 \%, \mathrm{~T}_{\text {mum }}$ to $\left.\mathrm{m}_{\text {mux }}\right)$ - see figures 14 through 18.

| Symbol | Parameter | Min | Max | Units |
| :---: | :---: | :---: | :---: | :---: |
| f | Clock in Frequency | 1 | 12.8 | MHz |
| $\mathrm{t}_{\text {CLK }}$ | Clock in Period ( $=1 / \mathrm{f}$ ) | 78 | 1000 |  |
| $\mathrm{t}_{\mathrm{D}}$ | Duty Cycle | $0.475 \mathrm{t}_{\text {CLK }}$ | $0.525 \mathrm{t}_{\text {CLK }}$ | ns |
| ${ }^{\text {t }}$ CL | Clock LOW | 37 | 41 | $\mathrm{ns}{ }^{1}$ |
|  |  | 475 | 525 | $\mathrm{ns}^{2}$ |
| ${ }^{\text {t }} \mathrm{CH}$ | Clock HIGH | 37 | 41 | ns ${ }^{1}$ |
|  |  | 475 | 525 | $\mathrm{ns}{ }^{2}$ |
| $\mathrm{t}_{\mathrm{R}}$ | Rise Time | 5 |  | ns |
| $\mathrm{t}_{\mathrm{F}}$ | Fall Time | 5 |  | ns |
| $\mathrm{t}_{\text {FSS }}$ | Frame Sync Input Setup Time | 20 | 78 | ns |
| $\mathrm{t}_{\text {FSH }}$ | Frame Sync Input Hold Time | 20 | -3 | ns |
| $\mathrm{t}_{\text {FSIL }}$ | Frame Sync Input LOW | 2 |  | $\mathrm{t}_{\text {CLK }}$ |
| $\mathrm{t}_{\text {DOD }}$ | Data Output Clock Delay | 25 | 75 | ns |
| $\mathrm{t}_{\text {DOP }}$ | Data Output Clock Period | 156 |  | $\mathrm{ns}{ }^{1,4}$ |
|  |  |  | 312 | $n \mathrm{~s}^{1,5}$ |
| $\mathrm{t}_{\text {FSOSC }}$ | FSO Setup Time Before CLKIN | 130 |  | $n 5^{5}$ |
| $\mathrm{t}_{\text {FSOHC }}$ | FSO Hold Time After CLKIN | 130 |  | $n 5^{5}$ |
| $\mathrm{t}_{\text {FSOSD }}$ | FSO Setup Time Before DOUT CLK | 110 |  | $n 5^{5}$ |
| $\mathrm{t}_{\text {FSOHD }}$ | FSO HIGH to DOUT CLK Rising Edge | 110 |  | $\mathrm{ns}^{5}$ |
| $\mathrm{t}_{\mathrm{IO}}$ | FSI to FSO Delay | 1 |  | $\mathrm{t}_{\mathrm{CLK}}{ }^{4}$ |
|  |  | 5 |  | $\mathrm{t}_{\mathrm{CLK}}{ }^{\text {S }}$ |
| $\mathrm{t}_{\text {DSU }}$ | Data Output Setup Time | 40 |  | $\mathrm{ns}^{4}$ |
|  |  | 130 |  | $n s^{5}$ |
| $\mathrm{t}_{\mathrm{DH}}$ | Data Output Hold Time | 40 |  | $n s^{4}$ |
|  |  | 130 |  | $n s^{5}$ |
| $\mathrm{t}_{\text {DD }}$ | Data Delay Time | 0 | 20 | ns |
| $\mathrm{t}_{\mathrm{DF}}$ | Data Float Time | 0 | 20 | ns |

## NOTES

${ }^{1}$ CLKIN $=12.8 \mathrm{MHz}$.
${ }^{2} \mathrm{CLKIN}=1 \mathrm{MHz}$.
${ }^{3}$ FSI must be deasserted for at least two CLKIN periods prior to being asserted.
${ }^{+}$Comb Filter mode.
${ }^{5}$ FIR Filter mode.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS*

$\mathrm{AV}_{\mathrm{DD}}$ to AGND . . . . . . . . . . . . . . . . . -0.3 V to +7.0 V
DV ${ }_{\text {DD }}$ to DGND . . . . . . . . . . . . . . . . . -0.3 V to +7.0 V
AGND to DGND . . . . . . . . . . . . . . . . . . . . . . . . $\pm 0.3$ V
Digital Inputs to DGND . . . . . . . . . . . . -0.3 V to $\mathrm{DV}_{\mathrm{DD}}$
Analog Inputs to AGND . . . . . . . . . . . . . -0.3 V to $\mathrm{AV}_{\mathrm{DD}}$
REFIN to AGND . . . . . . . . . . . . . . . . . -0.3 V to +2.5 V
Soldering (10 sec) . . . . . . . . . . . . . . . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Storage Temperature . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
*Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## CAUTION

The AD776 features input protection circuitry consisting of large "distributed" diodes and polysilicon series resistors to dissipate both high energy discharges (Human Body Model) and fast, low energy pulses (Charged Device Model). Per Method 3015.2 of MIL-STD-883C, the AD776 has been classified as a Category 1 Device.
Proper ESD precautions are strongly recommended to avoid functional damage or performance degradation. Charges as high as 4000 volts readily accumulate on the human body and test equipment, and discharge without detection. Unused devices must be stored in conductive foam or shunts,
 and the foam discharged to the destination socket before devices are removed. For further information on ESD precaution, refer to Analog Devices' ESD Prevention Manual.

## AD776 PIN DESCRIPTION

| Symbol | Pin Number | Type | Name and Function |
| :---: | :---: | :---: | :---: |
| AGND | 1 |  | Analog Ground. Return current for analog front end. No internal connection to DGND. |
| AIN+ | 2 | I. | Analog Signal Input. Noninverting terminal. |
| AIN- | 3 | I | Analog Signal Input. Inverting terminal. |
| CLKIN | 4 | I | Clock In. This TTL compatible input accepts clock frequencies in the range of $1.0 \mathrm{MHz}-12.8 \mathrm{MHz}$, with the output sample rate of the AD776 equal to CLKIN divided by 128 in FIR filter mode and 32 in comb filter mode. |
| FSI | 5 | I | Frame Sync Input. FSI is an optional control pin used to synchronize internal circuits and to start or reset the serial output data. If FSI is grounded, frame syncs will be automatically generated internally. When FSI is brought HIGH, serial data is presented at the output (DOUT-Pin 11). The purpose of FSI is to control externally the phasing of the A/D conversion process. FSI should be a periodic signal occurring every 16 DOUT CLK clock cycles in the $12-\mathrm{bit} / 400 \mathrm{kHz}$ mode and every 32 DOUT CLK clock cycles in the 16 -bit/ 100 kHz mode. When utilized, FSI must be synchronized to CLKIN as defined in the timing specification (see Figure 17). FSI allows multiple AD776s to be synchronized using a common frame sync source, requiring a common CLKIN signal. |
| FSEL | 6 | I | Filter Select. FSEL $=$ " 0 " selects FIR output. FSEL $=$ " 1 " selects comb filter output. |
| SF | 7 | I | Serial Format. Selects output format of DOUT and FSO when FSEL $=$ " 0. " See Figures 14b and 15b. |
| DV ${ }_{\text {DD }}$ | 8 |  | $+5 \mathrm{~V} \pm 10 \%$. Digital Power Supply. |
| FSO | 9 | 0 | Frame Sync Output. Indicates beginning of serial data transmission on DOUT. See Timing Diagrams. |
| DOUT CLK | 10 | O | Serial Data Clock. See Figures 14a and 14b. In the FIR filter output mode ( $\mathrm{FSEL}=0$ ), DOUT CLK is CLKIN divided by four; in the comb filter output mode (FSEL $=1$ ), DOUT CLK is CLKIN divided by two. |
| DOUT | 11 | 0 | Data Output. Serial data is transmitted MSB first, twos complement format, once per FSO cycle with the data synchronous with DOUT CLK. |
| $\overline{\text { DOE }}$ | 12 | I | Data Output Enable. Serial data (Pin 11) is an active output when $\overline{\mathrm{DOE}}=$ " $0 . "$ Serial data is three stated when $\overline{\mathrm{DOE}}=$ " 1. ." |
| DGND | 13 |  | Digital Ground. Return current for digital circuitry and pad drivers. |
| TP3, TP2, TP1, TP0 | 14, 15, 16, 17 |  | Test Points. These pins must be connected to DGND. |
| $\mathrm{AV}_{\text {DD }}$ | 18 |  | $+5 \mathrm{~V} \pm 10 \%$. Analog Power Supply. |
| REFOUT | 19 | 0 | Internal Reference Output. Nominally +2 V with $\mathrm{AV}_{\mathrm{DD}}=+5.0 \mathrm{~V}$. |
| REFIN | 20 | I | Reference Input. +2 V maximum. |

## I = Input

$\mathrm{O}=$ Output

## PIN CONFIGURATION

## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD776AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 20-Pin Cerdip | Q-20 |

*For outline information see Package Information section.

## TOTAL HARMONIC DISTORTION

Total Harmonic Distortion (THD) is the ratio of the rms sum of the harmonic components to the rms value of a full-scale input signal and is expressed in percent (\%) or decibels (dB).

## SIGNAL-TO-NOISE RATIO (SNR)

Signal-to-Noise Ratio (SNR) is defined to be the ratio of the rms value of the measured input signal to the rms sum of all other spectral components below the passband.

## INTERMODULATION DISTORTION (IMD)

With inputs consisting of sine waves at two frequencies, fa and fb , any device with nonlinearities will create distortion products, of order ( $\mathrm{m}+\mathrm{n}$ ), at sum and difference frequencies of $\mathrm{mfa} \pm \mathrm{nfb}$, where $\mathrm{m}, \mathrm{n}=0,1,2,3 \ldots$ Intermodulation terms are those for which $m$ or $n$ is not equal to zero. For example, the second order terms are ( $\mathrm{fa}+\mathrm{fb}$ ) and ( $\mathrm{fa}-\mathrm{fb}$ ), and the third order terms are $(2 f a+f b),(2 f a-f b),(f a+2 f b)$ and $(f a-2 f b)$. The IMD products are expressed as the decibel ratio of the rms sum of the measured input signals to the rms sum of the distortion terms. The two signals applied to the converter are of equal amplitude and the IMD products are normalized to a 0 dB input signal.

## DIFFERENTIAL NONLINEARITY (DNL)

In an ideal ADC, code transitions are one LSB apart. Differential nonlinearity is the maximum deviation from this ideal value. It is often specified in terms of resolution for which no missing codes are guaranteed.

## INTEGRAL NONLINEARITY (INL)

The ideal transfer function for an ADC is a straight line drawn between "zero" and "full scale." The point used as "zero" occurs $1 / 2$ LSB before the most negative code transition. "Full scale" is defined as a level $11 / 2$ LSB beyond the most positive code transition. INL is the worst-case deviation of a code center average from the straight line.

## GAIN ERROR

The last transition should ideally occur at an analog value 1.5 LSB below the nominal full scale. The gain error is the deviation of the actual difference between the first and last code transition from the ideal difference between the first and last code transition.

## MIDSCALE ERROR

Midscale error is the difference between the ideal midscale analog input voltage and the actual voltage producing the midscale output code.

## PASSBAND

The passband is the region of the frequency spectrum unaffected by the attenuation of the decimation filter. In the case of the AD776, the passband is a function of the CLKIN frequency (see Table I).

## PASSBAND RIPPLE

Passband ripple is defined as the variation in the amplitude response of the converter for input signal frequencies within the passband.

## STOPBAND

The stopband is the region of the frequency spectrum in which the amplitude response is fully attenuated by the digital filter. In the case of the AD776, the stopband is a function of the CLKIN frequency (see Table I).

## STOPBAND ATTENUATION

Stopband attenuation is defined to be the amount by which spectral components in the stopband are attenuated by the digital filter relative to the full-scale input range of the converter.

## POWER SUPPLY REJECTION

DC variations in the power supply voltage will affect the midscale transition point, resulting in offset error. Power supply rejection is the maximum change in the midscale transition point due to a change in power-supply voltage from the nominal value. Additionally, there is another power supply variation to consider. AC ripple on the power supplies can couple noise into the ADC, resulting in degradation of dynamic performance.

## GENERAL OVERVIEW

The AD776 is a single supply ( +5 V ) ADC providing simple analog and digital interface requirements. A minimal number of external connections are required to achieve the specified performance:

1. POWER
2. GROUNDS
3. CLOCKING
4. INPUT BUFFER CIRCUIT

These points will be further explored in the Application Information section.

## THEORY OF OPERATION

The AD776 differs from traditional multi-bit ADCs through its use of sigma-delta conversion architecture. A 1-bit analog-to-
digital conversion is performed at a very high rate, which redistributes quantization noise to beyond the frequency band of interest (see Figure 1). The frequency band of interest is denoted by $\mathrm{f}_{\mathrm{C}}$, and $\mathrm{f}_{\mathrm{S}}$ is the sample frequency; $\mathrm{f}_{\mathrm{S}} / 2$ is the expanded noise spectrum resulting from oversampling. The total noise energy remains constant, but by spreading it over a wider spectrum, the amount in the frequency band of interest is reduced. Noise shaping, performed by the modulator, attenuates noise in the signal passband and pushes out the noise energy into the higher frequency range (Figure 2). The oversampled signal is presented to the digital filter circuitry for:

- sophisticated averaging (filtering).
- removing high frequency noise (quantization noise removal).
- reducing sampling rate (decimation).

The resulting output data stream is presented in a format equivalent to a traditional ADC at a much reduced output sample rate.


Figure 1. Noise Spectrum from Oversampling


Figure 2. Noise Shaping
Figure 3 provides a block diagram of the various sections of the AD776. The Analog Front End is comprised of three differential switched-capacitor linear integrators which perform the noise-shaping function. Digital filter complexity of the AD776 is reduced by performing the filtering and decimation in two stages. The first section contains a 16:1 decimating comb filter stage with the output presented to a $4: 1$ decimating low-pass/ compensation FIR filter, resulting in a final decimation ratio of 64:1. The decimation function is described in detail in the DECIMATION paragraph. The output data is presented in twos complement, MSB first serial data format, providing serial communication to a host processor.
This interface uses three dedicated pins: serial data output (DOUT), frame sync output (FSO), and serial clock output (DOUT CLK). The serial interface format of operation is pin selectable. The timing diagrams for the serial interface are described in the DIGITAL TIMING section.


Figure 3. Block Diagram

## ANALOG FRONT-END

The integrators of the third-order modulator front-end form a differential switched-capacitor network which results in increased signal swing, increased power supply rejection, and reduced sensitivity to clock jitter. Due to the nature of switched-capacitor circuits, the input impedance of AIN + , AIN-, and REFIN will vary with clock frequency. More information about these inputs is given in Table II and Table III.
The AD776 modulator is a third-order noise shaper which reduces quantization noise in the passband to the 16-bit level. The input signal is sampled at the rate of CLKIN/4. Since the input signal is oversampled by a factor of 64 , a complex antialiasing filter is not needed; a single-pole RC filter will generally be sufficient. High quality polystyrene or NPO ceramic capacitors should be used for this filter.

## DIGITAL FILTER OVERVIEW

The digital filters of the AD776 have two functions: high performance low-pass filtering and digital decimation. The shaped quantization noise from the output of the modulator is low-pass filtered to reduce the out-of-band noise components to a level which will not alias into the passband during the decimation process. Decimation then reduces the data rate to a manageable level.

## DECIMATION

The comb filter performs the first-stage filtering of the analog front-end's quantized and noise-shaped output and decimates the input sample rate by a factor of $16: 1$. The $z$-domain transfer function for the comb filter is expressed by

$$
H(z)=\frac{\left(1-z^{-16}\right)^{4}}{\left(1-z^{-1}\right)^{4}}
$$

The frequency domain equivalent transfer function is

$$
H(f)=\left[\frac{1}{16} \frac{\sin (16 \pi f T)}{\sin (\pi f T)}\right]^{4}
$$

where $T=1 / f_{S}$
$f_{S}=$ the input sample rate for the Analog Front End (maximum 6.4 MHz ).

The attenuation characteristics of the comb filter are shown in Figure 4. As illustrated, the frequency response in the passband region exhibits a nonflat behavior. In the 400 kHz mode, the output of the comb filter provides conversion data. The dynamic range is equivalent to approximately 72 dB , or 12 bits, in this mode. In the $16-\mathrm{bit} / 100 \mathrm{kHz}$ mode, the comb filter serves as the input to the FIR filter. The FIR filter compensates for the passband roll-off of the comb filter and provides the final sharp cutoff required for stopband attenuation, removing the out-of-band noise components while partially serving as the system antialiasing filter.


Figure 4. Comb Filter Response
Figure 5 illustrates the low-pass response of the FIR filter and Figure 6 shows the compensation function of the filter. The 255-tap FIR filter is low-pass with $9 \%$ transition-band, and with a CLKIN frequency of 12.8 MHz has a 45.5 kHz passband cutoff frequency, 50 kHz stopband frequency, 0.001 dB passband ripple, and a stopband ripple of -96 dB .


Figure 5. FIR Filter, Low-Pass Response


Figure 6. FIR Filter, Compensation Function
The passband and stopband frequencies of both the comb and FIR filters scale linearly with the CLKIN frequency, as shown in Table I.

Table I. FIR and Comb Filter Characteristics

| CLKIN <br> $(\mathbf{M H z})$ | Passband <br> $(\mathbf{k H z})$ | Stopband <br> $(\mathbf{k H z})$ |
| :--- | :--- | :--- |
| 12.8 | 45.5 | 50 |
| 12.288 | 43.7 | 48 |
| 11.2896 | 40.1 | 44.1 |
| 10.0 | 35.5 | 39.1 |
| 6.4 | 24.6 | 27.1 |

## ANALOG INPUT

The input to the AD776, as previously described in the discussion of the analog front end, uses a switched-capacitor structure. As a result, the input impedance of AIN+ and AIN - will vary with clock frequency. Table II gives the typical analog input impedance for some common CLKIN frequencies. The input impedance is equal to $\approx 10^{12} / 3 \mathrm{f}_{\text {CLKIN }}$, where $\mathrm{f}_{\text {CLKIN }}$ is the input clock rate.

Table II. Analog Input Impedance

|  | Output <br> Input | Analog <br> Cample |
| :--- | :--- | :--- |
| Clock Rate | Rate (kHz) | Input <br> $(\mathbf{M H z})$ |
| 12.8 | (FIR Filter Mode) | Impedance |
| 6.4 | 100 | 26 |
| 6.144 | 50 | 52 |
| 5.6448 | 48 | 54.3 |

The AD776 is designed to accept input signals of ( $2 \times \mathrm{V}_{\mathrm{REF}}$ ) -0.5 V which can be centered at various dc offsets (commonmode inputs) as long as the signal peaks are bounded by +4.0 V and 0 V . Signal peaks outside this range will result in signal clipping and increased distortion products.
Capacitive coupling between the CLKIN and AIN pins can cause degradation to dynamic performance. Special care should be taken with respect to the layout of the clock and analog inputs.

In consideration of the dynamic characteristics of the analog input, an external op amp is generally required to provide a low impedance drive. Care should be taken with op amp selection; even with modest loading conditions, most available op amps do not meet the low distortion requirements necessary to match the performance capabilities of the AD776. The AD712 op amp is a good choice for low noise and low distortion.

## SINGLE-ENDED INPUT CONFIGURATIONS

The differential input of the AD776 provides a choice of several different input connections. Figure 7 shows a simple configuration for a single-ended input. AIN- is nominally biased at +2.5 V by resistively dividing the +5 V power supply ( $\mathrm{AV}_{\mathrm{DD}}$ ). Since the analog input impedance is a function of the input clock rate, determination of bias resistor values to achieve a particular bias voltage will vary with clock rate and $A V_{D D}$.
The circuit shown in Figure 7 is a low cost, minimal component solution, but may suffer from poor power supply rejection as noise present on the power supply could be coupled directly into the AIN- pin. An improved input circuit is shown in Figure 8, where the offset voltage is derived from the AD680 voltage reference. The AD680 has $40 \mu \mathrm{~V} / \mathrm{V}$ line regulation which results in only a $20 \mu \mathrm{~V}$ error due to $10 \%$ supply fluctuation. This improves power supply rejection of AIN - input to approximately 88 dB .


Figure 7. Simple Single-Ended Input Circuit


Figure 8. Single-Ended Input Circuit for Improved PSRR
For optimal performance in single-ended input applications, the circuit in Figure 9 may be used to convert the input to a differential signal.


Figure 9. Single-Ended Input to Differential Circuit

## REFERENCE INPUT

The AD776 has an on-chip $0.4 \mathrm{~V}_{\text {DD }}$ reference voltage circuit which can be used to drive REFIN, as shown in Figure 10. Alternately, an external voltage reference may be used to supply the required 2 V . REFIN exhibits characteristics similar to the Analog Input in that the input impedance is a function of the clock rate. This is illustrated in Table III. The minimum reference impedance is equal to $10^{12} / 2.5 \mathrm{f}_{\mathrm{CLK}}$, where $\mathrm{f}_{\mathrm{CLK}}$ is the input clock rate.

Table III. Reference Input Impedance

| Input <br> Clock Rate <br> (MHz) | Output <br> Sample <br> Rate ( $\mathbf{k H z \text { ) }}$ | Reference <br> Input <br> Impedance <br> ( $\mathbf{k} \Omega \mathrm{min}$ ) |
| :---: | :---: | :---: |
| 12.8 | 100 | 31.3 |
| 6.4 | 50 | 62.5 |
| 6.144 | 48 | 65.1 |
| 5.6448 | 44.1 | 70.9 |



Figure 10. Simple Reference Voltage Circuit
While the internal reference will be adequate for most applications, power supply rejection and overall regulation may be improved through the use of an external reference. The process of selecting an external voltage reference should include consideration of drive capability, initial error, noise, and drift characteristics. A suitable choice would be the AD680 as shown in Figure 11.


Figure 11. External Voltage Reference Circuit

## MULTIPLEXING

The AD776 can also be used with an input multiplexer when the comb filter output is selected by setting FSEL $=1$. If $\mathrm{f}_{\mathrm{CLK}}$ $=12.8 \mathrm{MHz}$, the minimum multiplex intervals are (including the time to shift the data out from the serial interface):
$15 \mu \mathrm{~s} \quad$ (if the FSI and mux are perfectly synchronized) $17.5 \mu \mathrm{~s}$ (if the FSI and mux are not synchronized).

## CLOCK GENERATION

With sigma-delta converters, it is critical that clock jitter be minimized in order to achieve optimal performance. Figure 12 illustrates a simple circuit used to derive a clock source for the AD776. An alternative would be to use an oscillator such as the CK1100 series from Cardinal Components (Montclair, NJ) or the F1100 from Fox Electronics. Compared with performance obtained with a typical crystal, use of an oscillator improves SNR by approximately 4 dB .


Figure 12. Basic Clock Circuit

## BOARD LAYOUT

Designing with high resolution data converters requires careful attention to board layout. Trace impedance is a significant issue. A 1.22 mA current through a $0.5 \Omega$ trace will develop a voltage drop of 0.6 mV , which is 20 LSBs at the 16 bit level for a 2 V full-scale span. In addition to ground drops, inductive and capacitive coupling need to be considered, especially when high accuracy analog signals share the same board with digital signals.

Analog and digital signals should not share a common return path. Each signal should have an appropriate analog or digital return routed close to it. Using this approach, signal loops enclose a small area, minimizing the inductive coupling of noise. Wide PC tracks, large gauge wire, and ground planes are highly recommended to provide low impedance signal paths. Separate analog and digital ground planes are also desirable, with a single interconnection point at (or under) the part to minimize ground loops. This is preferred to interconnecting the grounds at the supplies.

Analog signals should be routed as far as possible from digital signals and should cross them, if at all, only at right angles. The AD776 may be treated as an analog component, with both AGND and DGND connected to a single analog ground plane. This helps to isolate the AD776 from large digital ground currents. For these reasons, the use of wire wrap circuit construction will not provide adequate performance; careful printed circuit board construction is preferred.

## POWER SUPPLIES AND DECOUPLING

With high performance linear circuits, changes in the power supplies can produce undesired changes in the performance of the circuit. Optimally, well regulated power supplies with less than $1 \%$ ripple should be selected. The ac output impedance of a power supply is a complex function of frequency, but in general will increase with frequency. High frequency switching such as that encountered with digital circuitry requires fast transient currents which most power supplies cannot adequately provide. This results in voltage spikes on the supplies. To compensate for the finite ac output impedance of the supplies, it is necessary to store "reserves" of charge in bypass capacitors. These capacitors can effectively lower the ac impedance presented to the AD776 power inputs which in turn will significantly reduce the magnitude of the voltage spikes. Decoupling capacitors, typically $0.1 \mu \mathrm{~F}$, should be placed as close as possible to each power supply pin of the AD776. It is essential that these capacitors be placed physically close to the AD776 to minimize the inductance of the PCB trace between the capacitor and the supply pin.
Additionally, it is beneficial to have large capacitors ( $>47 \mu \mathrm{~F}$ ) located at the point where the power connects to the PCB with $10 \mu \mathrm{~F}$ capacitors located in the vicinity of the ADC to further reduce low frequency ripple.
The AD776 may be operated from a single +5 V supply. However, performance is optimized by using separate analog ( $\mathrm{AV}_{\mathrm{DD}}$ ) and digital ( $\mathrm{DV}_{\mathrm{DD}}$ ) supplies. Separate supplies enable isolation of digital noise from the analog circuitry. When separate supplies are used, $\mathrm{AV}_{\mathrm{DD}}$ should be decoupled to analog ground (AGND) and DV $_{\text {DD }}$ should be decoupled to digital ground (DGND) with decoupling capacitors.
When a single +5 V supply is used, the circuit shown in Figure 13 provides adequate decoupling.


Figure 13. Single Supply Decoupling

## DIGITAL TIMING

The CLKIN frequency and the choice of output filter mode (FIR or Comb) determine the output sample rate of the AD776. With FSEL LOW, the FIR filter output is selected and the output rate is equal to CLKIN divided by 128. When FSEL is HIGH, the Comb filter is selected and the output sample rate is equal to CLKIN divided by 32 . The input sample rate (or modulator frequency) is always the CLKIN frequency divided by 2.
The flexible serial data output interface of the AD776 may be configured in one of three modes. MODE A and MODE B are used when the FIR filter output is desired. MODE C should be selected when output from the comb filter is used. Output data is always transmitted as 16 -bit, twos complement, MSB first, serial words. In all modes, the FSI pin may be asserted to reset the serial data output and synchronize internal circuits. A $\overline{\mathrm{DOE}}$ pin is available to place the DOUT pin in a high impedance state.
Configuring the appropriate timing mode is controlled by the FSEL and SF pins. The truth table is shown in Table IV.

Table IV. Timing Mode Truth Table

| FSEL | SF | Output Mode |
| :---: | :---: | :---: |
| 0 | 0 | A |
| 0 | 1 | B |
| 1 | 0 | C |

## MODE A

The timing diagrams for MODE A are shown in Figures 14a and 14 b . If MODE A is selected, an internal multiplexer routes serial data from the output of the FIR filter to the DOUT pin. The output sample rate is a function of the clock present at the CLKIN pin where:

$$
\text { Output Sample Rate }=\text { CLKIN/ } 128
$$

A continuous serial output clock, DOUT CLK, is available with the bit rate determined by:
DOUT CLKK = CLKIN/4.

Serial data from the DOUT pin is valid on the falling edges of DOUT CLK. A framing signal, FSO, occurs with a period equal to the output sample rate (Figure 14b). The FSO signal is HIGH during the falling edge of DOUT CLK prior to the beginning of a new output data word.


Figure 14a. Mode A Timing


Figure 14b. Mode A Timing

MODE B
The timing diagrams for MODE B are shown in Figures 15a and 15 b . If Mode B is selected, the internal multiplexer routes serial data from the output of the FIR filter to the DOUT pin similar to MODE A. The output sample rate is a function of the clock present at the CLKIN pin where:

Output Sample Rate $=$ CLKIN/128.
A continuous serial output clock, DOUT CLK, is available with
the bit rate determined by:

$$
\text { DOUT CLK }=C L K I N / 4
$$

Note that serial data present at the DOUT pin is valid on the rising edges of DOUT CLK. The framing signal, FSO, occurs with a period equal to the output sample rate. In MODE B, the FSO signal goes LOW at the beginning of the output data word and remains LOW until the entire word is transmitted.


Figure 15a. Mode B Timing


Figure 15b. Mode B Timing

MODE C
The timing diagrams for MODE C are shown in Figure 16. If Mode C is selected, the internal multiplexer routes serial data from the output of the COMB filter to the DOUT pin, bypassing the FIR filter. The output sample rate is a function of the clock present at the CLKIN pin where:

$$
\text { Output Sample Rate }=C L K I N / 32 .
$$

A continuous serial output clock, DOUT CLK, is available with
the bit rate determined by:

$$
\text { DOUT CLK }=\text { CLKIN/2. }
$$

Serial output data is valid on the falling edges of DOUT CLK. The framing signal, FSO, occurs with a period equal to the output sample rate. The FSO signal is HIGH during the falling edge of DOUT CLK prior to transmission of the next output data word. Note that in MODE C, this is also when the LSB, (D0), of the previous data word is valid.


Figure 16. Mode C Timing

## FSI Operation

A frame sync input is available to the user on the FSI pin to reset the serial data output and synchronize internal circuits.
Referring to Figure 17, the FSI pin is sampled on the falling edge of CLKIN. The FSI pin must adhere to several conditions depending on which mode is being used as follows:
FSI in MODE A, MODE B

1. FSI should be a periodic signal occurring every 32 DOUT CLK periods.
2. FSI must be deasserted for at least 2 CLKIN periods prior to being asserted.
3. FSI must be synchronized to CLKIN to meet the timing requirements outlined in Figure 17.

## FSI in MODE C

1. FSI should be a periodic signal occurring every 16 DOUT CLK periods.
2. FSI must be deasserted for at least 2 CLKIN periods prior to being asserted.
3. FSI must be synchronized to CLKIN to meet the timing requirements outlined in Figure 17.


Figure 17. Frame Sync Input (FSI) Timing (FIR Filter Output Mode)

## Synchronizing Two Channels

The FSI pin is useful when multiple AD776s are used together and must be synchronized. In such a case, a single pulse may be applied to FSI inputs of the converters. This causes the internal "state-machine" of the AD776 to be reset. Thus, the internal clocking for both the analog and digital circuitry of each individual converter is synchronized and in-phase. In the case of a single FSI pulse, it must still adhere to the timing outlined in Figure 17.

## Three-Stating the DOUT Pin ( $\overline{\mathrm{DOE}}$ )

In all modes DOUT may be three-stated using the $\overline{\overline{D O E}}$ pin. Operation of the $\overline{\mathrm{DOE}}$ input is shown in Figure 18. When the $\overline{\mathrm{DOE}}$ input is HIGH, serial data will be present and active at the DOUT pin. When $\overline{\mathrm{DOE}}$ is brought LOW, the DOUT pin is placed in a high-impedance state. $\overline{\mathrm{DOE}}$ is completely asynchronous and independent of input and output clocks. DOUT loading will affect actual performance.


Figure 18. Data Output Timing

## INTERFACING THE AD776

The AD776 is designed for ease of interface with a variety of popular processors. The following diagrams illustrate typical configurations:


Figure 19.

## FEATURES

AC and DC Characterized and Specified (K, B, T Grades)<br>128k Conversions per Second<br>1 MHz Full Power Bandwidth<br>500 kHz Full Linear Bandwidth<br>80 dB S/N+D (K, B, T Grades)<br>Twos Complement Data Format (Bipolar Mode)<br>Straight Binary Data Format (Unipolar Mode)<br>$10 \mathrm{M} \Omega$ Input Impedance<br>16-Bit Bus Interface (See AD679 for 8-Bit Interface)<br>On-Board Reference and Clock<br>10 V Unipolar or Bipolar Input Range<br>MIL-STD-883 Compliant Versions Available

## PRODUCT DESCRIPTION

The AD779 is a complete, multipurpose 14-bit monolithic analog-to-digital converter, consisting of a sample-hold amplifier (SHA), a microprocessor compatible bus interface, a voltage reference and clock generation circuitry.
The AD779 is specified for ac (or "dynamic") parameters such as $\mathrm{S} / \mathrm{N}+\mathrm{D}$ ratio, THD and IMD which are important in signal processing applications. In addition, the AD779K, B and T grades are fully specified for dc parameters which are important in measurement applications.

The 14 data bits are accessed by a 16 -bit bus in a single read operation. Data format is straight binary for unipolar mode and twos complement binary for bipolar mode. The input has a fullscale range of 10 V with a full power bandwidth of 1 MHz and a full linear bandwidth of 500 kHz . High input impedance ( $10 \mathrm{M} \Omega$ ) allows direct connection to unbuffered sources without signal degradation.

This product is fabricated on Analog Devices' BiMOS process, combining low power CMOS logic with high precision, low noise bipolar circuits; laser-trimmed thin-film resistors provide high accuracy. The converter utilizes a recursive subranging algorithm which includes error correction and flash converter circuitry to achieve high speed and resolution.
The AD779 operates from +5 V and $\pm 12 \mathrm{~V}$ supplies and dissipates 560 mW (typ). Twenty-eight-pin plastic DIP and ceramic DIP packages are available.

[^16]FUNCTIONAL BLOCK DIAGRAM


## PRODUCT HIGHLIGHTS

1. COMPLETE INTEGRATION: The AD779 minimizes external component requirements by combining a high speed sample-hold amplifier (SHA), ADC, 5 V reference, clock and digital interface on a single chip. This provides a fully specified sampling A/D function unattainable with discrete designs.
2. SPECIFICATIONS: The AD779K, B and T grades provide fully specified and tested ac and dc parameters. The AD779J, A and S grades are specified and tested for ac parameters; dc accuracy specifications are shown as typicals. DC specifications (such as INL, gain and offset) are important in control and measurement applications. AC specifications (such as $\mathrm{S} / \mathrm{N}+\mathrm{D}$ ratio, THD and IMD) are of value in signal processing applications.
3. EASE OF USE: The pinout is designed for easy board layout, and the single cycle read output provides compatibility with 16 -bit buses. Factory trimming eliminates the need for calibration modes or external trimming to achieve rated performance.
4. RELIABILITY: The AD779 utilizes Analog Devices' monolithic BiMOS technology. This ensures long term reliability compared to multichip and hybrid designs.
5. The AD779 is available in versions compliant with MIL-STD-883. Refer to the Analog Devices Military Products Databook or current AD779/883B data sheet for detailed specifications.

## AD779-SPECIFICATIONS



| Parameter | AD779J/A/S |  |  | AD779K/B/T |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max |  |
| SIGNAL-TO-NOISE AND DISTORTION (S/N+D) RATIO |  |  |  |  |  |  | dB |
| -0.5 dB Input (Referred to -0 dB Input) ${ }^{\text {a }}$ ( ${ }^{\text {a }}$ | 78 | 79 |  | 80 | 81 |  |  |
| -20 dB Input (Referred to -20 dB Input) | 58 | 59 |  | 60 | 61 |  | dB |
| -60 dB Input (Referred to -60 dB Input) | 18 | 19 |  | 20 | 21 |  | dB |
| TOTAL HARMONIC DISTORTION (THD) |  |  |  |  |  |  |  |
| @ $+25^{\circ} \mathrm{C}$ |  | -90 | -84 |  | -90 | -84 | $\begin{aligned} & \mathrm{dB} \\ & \% \\ & \mathrm{~dB} \\ & \% \end{aligned}$ |
| $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ |  | 0.003 | 0.006 | , | 0.003 | 0.006 |  |
|  |  | -88 | -82 | * | -88 | -82 |  |
|  |  | 0.004 | 0.008 |  | 0.004 | 0.008 |  |
| PEAK SPURIOUS OR PEAK HARMONIC COMPONENT |  | -90 | -84 |  | -90 | -84 | dB |
| FULL POWER BANDWIDTH | 1 |  |  | 1 |  |  | MHz |
| FULL LINEAR BANDWIDTH | 500 |  |  | 500 |  |  | kHz |
| INTERMODULATION DISTORTION (IMD) ${ }^{2}$ |  |  |  |  |  |  |  |
| 2nd Order Products |  | -90 | -84 |  | -90 | -84 | dB |
| 3rd Order Products |  | -90 | -84 |  | -90 | -84 | dB |

DIGITAL SPECIFICATIONS (All device types $\mathrm{T}_{\min }$ to $\mathrm{T}_{\max }, \mathrm{V}_{\mathrm{CC}}=+12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{EE}}=-12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{DD}}=+5 \mathrm{~V} \pm 10 \%$ )

| Parameter | Test Conditions | Min | Max | Units |
| :---: | :---: | :---: | :---: | :---: |
| LOGIC INPUTS |  |  |  |  |
| $\mathrm{V}_{\mathrm{IH}}$. High Level Input Voltage |  | 2.0 | $\mathrm{V}_{\text {DD }}$ | V |
| $\mathrm{V}_{\text {IL }} \quad$ Low Level Input Voltage |  | 0 | 0.8 | V |
| $\mathrm{I}_{\mathrm{IH}} \quad$ High Level Input Current | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{DD}}$ | -10 | +10 | $\mu \mathrm{A}$ |
| IIL Low Level Input Current | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}$ | -10 | +10 | $\mu \mathrm{A}$ |
| $\mathrm{C}_{\text {IN }} \quad$ Input Capacitance |  |  | 10 | pF |
| LOGIC OUTPUTS |  |  |  |  |
| $\mathrm{V}_{\text {OH }} \quad$ High Level Output Voltage | $\mathrm{I}_{\mathrm{OH}}=0.1 \mathrm{~mA}$ | 4.0 |  | V |
|  | $\mathrm{I}_{\mathrm{OH}}=0.5 \mathrm{~mA}$ | 2.4 |  | V |
| $\mathrm{V}_{\text {OL }}$ Low Level Output Voltage | $\mathrm{I}_{\text {OL }}=1.6 \mathrm{~mA}$ |  | 0.4 | V |
| $\mathrm{I}_{\mathrm{OZ}} \quad$ High Z Leakage Current | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {DD }}$ | -10 | +10 | $\mu \mathrm{A}$ |
| $\mathrm{C}_{\mathrm{OZ}}$ High Z Output Capacitance |  |  | 10 | pF |

NOTES
${ }^{1} \mathrm{f}_{\mathrm{IN}}$ amplitude $=-0.5 \mathrm{~dB}(9.44 \mathrm{~V} p-\mathrm{p})$ bipolar mode full scale unless otherwise indicated. All measurements referred to a $-0 \mathrm{~dB}(9.997 \mathrm{~V} \mathrm{p}-\mathrm{p})$ input signal unless otherwise noted.
${ }^{2} \mathrm{f}_{\mathrm{A}}=9.08 \mathrm{kHz}, \mathrm{f}_{\mathrm{B}}=9.58 \mathrm{kHz}$, with $\mathrm{f}_{\text {SAMPLE }}=128 \mathrm{kSPS}$.
Specifications subject to change without notice.

DC SPECIFICATIONS ${ }^{\left(\mathrm{T}_{\min }\right.}$ to $\mathrm{T}_{\max }, \mathrm{V}_{\mathrm{cc}}=+12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{EE}}=-12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{DO}}=+5 \mathrm{~V} \pm 10 \%$ unless otherwise indicated)

| Parameter | AD779J/A/S |  |  | AD779K/B/T |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max |  |
| TEMPERATURE RANGE |  |  |  |  |  |  |  |
| J, K Grades | 0 |  | +70 | 0 |  | +70 | ${ }^{\circ} \mathrm{C}$ |
| A, B Grades | -40 |  | +85 | -40 |  | +85 | ${ }^{\circ} \mathrm{C}$ |
| S, T Grades | -55 |  | +125 | -55 |  | +125 | ${ }^{\circ} \mathrm{C}$ |
| ACCURACY |  |  |  |  |  |  |  |
| Resolution | 14 |  |  | 14 |  |  | Bits |
| Integral Nonlinearity (INL) |  | $\pm 2$ |  |  | $\pm 1$ | $\pm 2$ | LSB |
| Differential Nonlinearity (DNL) | 14 |  |  | 14 |  |  | Bits |
| Unipolar Zero Error ${ }^{1}$ (@+259 ) |  | 0.08 |  |  | 0.05 | 0.07 | \% FSR* |
| Bipolar Zero Error ${ }^{1}$ (@+25${ }^{\circ} \mathrm{C}$ ) |  | 0.08 |  |  | 0.05 | 0.07 | \% FSR |
| Gain Error ${ }^{1,2}$ (@+25 ${ }^{\circ} \mathrm{C}$ ) |  | 0.12 |  |  | 0.09 | 0.11 | \% FSR |
| Temperature Drift |  |  |  |  |  |  |  |
| Unipolar Zero ${ }^{3}$ |  |  |  |  |  |  |  |
| J, K Grades |  | 0.04 |  |  | 0.04 | 0.05 | \% FSR |
| A, B Grades |  | 0.05 |  |  | 0.05 | 0.07 | \% FSR |
| S, T Grades |  | 0.09 |  |  | 0.09 | 0.10 | \% FSR |
| Bipolar Zero ${ }^{3}$ |  |  |  |  |  |  |  |
| J, K Grades |  | 0.02 |  |  | 0.02 | 0.04 | \% FSR |
| A, B Grades |  | 0.04 |  |  | 0.04 | 0.06 | \% FSR |
| S, T Grades |  | 0.08 |  |  | 0.08 | 0.09 | \% FSR |
| Gain ${ }^{3}$ |  |  |  |  |  |  |  |
| J, K Grades |  | 0.09 |  |  | 0.09 | 0.11 | \% FSR |
| A, B Grades |  | 0.10 |  |  | 0.10 | 0.16 | \% FSR |
| S, T Grades |  | 0.20 |  |  | 0.20 | 0.25 | \% FSR |
| Gain $^{4}$ ( $0.04{ }^{\text {a }}$ |  |  |  |  |  |  |  |
| J, K Grades |  | 0.04 |  |  | 0.04 | 0.05 | \% FSR |
| A, B Grades |  | 0.05 |  |  | 0.05 | 0.07 | \% FSR |
| S, T Grades |  | 0.09 |  |  | 0.09 | 0.10 | \% FSR |
| ANALOG INPUT |  |  |  |  |  |  |  |
| Input Ranges |  |  |  |  |  |  |  |
| Unipolar Mode | 0 |  | +10 | 0 |  | +10 | V |
| Bipolar Mode | -5 |  | +5 | -5 |  | +5 | V |
| Input Resistance |  | 10 |  |  | 10 |  | $\mathrm{M} \Omega$ |
| Input Capacitance |  | 10 |  |  | 10 |  | pF |
| Input Settling Time |  |  | 1.5 |  |  | 1.5 | $\mu \mathrm{s}$ |
| Aperture Delay |  | 10 |  |  | 10 |  | ns |
| Aperture Jitter |  | 150 |  |  | 150 |  | ps |
| INTERNAL VOLTAGE REFERENCE |  |  |  |  |  |  |  |
| Output Voltage ${ }^{5}$ | 4.98 |  | 5.02 | 4.98 |  | 5.02 | V |
| External Load |  |  |  |  |  |  |  |
| Unipolar Mode |  |  | +1.5 |  |  | +1.5 | mA |
| Bipolar Mode |  |  | +0.5 |  |  | +0.5 | mA |
| POWER SUPPLIES |  |  |  |  |  |  |  |
| Power Supply Rejection |  |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{CC}}=+12 \mathrm{~V} \pm 5 \%$ |  | $\pm 6$ |  |  |  | $\pm 6$ | LSB |
| $\mathrm{V}_{\mathrm{EE}}=-12 \mathrm{~V} \pm 5 \%$ |  | $\pm 6$ |  |  |  | $\pm 6$ | LSB |
| $\mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V} \pm 10 \%$ |  | $\pm 6$ |  |  |  | $\pm 6$ | LSB |
| Operating Current |  |  |  |  |  |  |  |
| $\mathrm{I}_{\mathrm{CC}}$ |  | 18 | 20 |  | 18 | 20 | mA |
| $\mathrm{I}_{\mathrm{EE}}$ |  | 25 | 34 |  | 25 | 34 | mA |
| $\mathrm{I}_{\mathrm{DD}}$ |  | 8 | 12 |  | 8 | 12 | mA |
| Power Consumption |  | 560 | 745 |  | 560 | 745 | mW |

## NOTES

${ }^{1}$ Adjustable to zero.
${ }^{2}$ Includes internal voltage reference error.
${ }^{3}$ Includes internal voltage reference drift.
${ }^{4}$ Excludes internal voltage reference drift.
${ }^{5}$ With maximum external load applied.
$\star \% \mathrm{FSR}=$ percent of full-scale range.
Specifications subject to change without notice.

TIMING SPECIFICATIONS
(All device types $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}, \mathrm{V}_{\mathrm{CC}}=+12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{EE}}=-12 \mathrm{~V}$ $\left.\pm 5 \%, V_{D D}=+5 V \pm 10 \%\right)$

| Parameter | Symbol | Min | Max | Units |
| :--- | :--- | :--- | :--- | :--- |
| Conversion Rate ${ }^{1}$ | $\mathrm{t}_{\mathrm{CR}}$ |  | 7.8 | $\mu \mathrm{~s}$ |
| Convert Pulse Width | $\mathrm{t}_{\mathrm{CP}}$ | 0.097 | 3.0 | $\mu \mathrm{~s}$ |
| Aperture Delay | $\mathrm{t}_{\mathrm{AD}}$ | 5 | 20 | ns |
| Conversion Time | $\mathrm{t}_{\mathrm{C}}$ |  | 6.3 | $\mu \mathrm{~s}$ |
| Status Delay | $\mathrm{t}_{\mathrm{SD}}$ | 0 | 400 | ns |
| Access Time ${ }^{2,3}$ | $\mathrm{t}_{\mathrm{BA}}$ | 10 | 100 | ns |
|  |  | 10 | $57^{+}$ | ns |
| Float Delay |  |  | 10 | 80 |
| Output Delay | $\mathrm{t}_{\mathrm{FD}}$ | ns |  |  |
| OE Delay | $\mathrm{t}_{\mathrm{OD}}$ |  | 0 | ns |
| Read Pulse Width | $\mathrm{t}_{\mathrm{OE}}$ | 20 |  | ns |
| Conversion Delay | $\mathrm{t}_{\mathrm{RP}}$ | 100 |  | ns |

## NOTES

${ }^{1}$ Includes Acquisition Time.
${ }^{2}$ Measured from the falling edge of $\overline{\mathrm{OE}} / \overline{\mathrm{EOCEN}}(0.8 \mathrm{~V})$ to the time at which the data lines/EOC cross 2.0 V or 0.8 V . See Figure 4.
${ }^{3} \mathrm{C}_{\mathrm{OLT}}=100 \mathrm{pF}$.
${ }^{+} \mathrm{C}_{\mathrm{OLT}}=50 \mathrm{pF}$.
${ }^{5}$ Measured from the rising edge of $\overline{\mathrm{OE} / \overline{\mathrm{EOCEN}}(2.0 \mathrm{~V}) \text { to the time at which }}$ the output voltage changes by 0.5 V . See Figure $4 ; \mathrm{C}_{\mathrm{OLT}}=10 \mathrm{pF}$.
Specifications subject to change without notice.


Figure 1. Conversion Timing


Figure 2. Output Timing


Figure 3. EOC Timing


Figure 4. Load Circuit for Bus Timing Specifications

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

| Specification | With Respect To | Min | Max | Units |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {CC }}$ | AGND | -0.3 | +18 | V |
| $\mathrm{V}_{\text {EE }}$ | AGND | -18 | +0.3 | V |
| $\mathrm{V}_{\mathrm{CC}}$ (Note 2) | $\mathrm{V}_{\text {EE }}$ | -0.3 | +26.4 | V |
| $V_{D D}$ | DGND | 0 | +7 | V |
| AGND | DGND | -1 | +1 | V |
| AIN, $\mathrm{REF}_{\text {IN }}$ | AGND | $\mathrm{V}_{\text {EE }}$ | $\mathrm{V}_{\mathrm{Cc}}$ | V |
| Digital Inputs | DGND | -0.5 | +7 | V |
| Digital Outputs | DGND | -0.5 | $\mathrm{V}_{\mathrm{DD}}+0.3$ | V |
| Max Junction Temperature |  |  | 175 | ${ }^{\circ} \mathrm{C}$ |
| Operating Temperature $J$ and K Grades |  | 0 | +70 | ${ }^{\circ} \mathrm{C}$ |
| A and B Grades |  | -40 | +85 | ${ }^{\circ} \mathrm{C}$ |
| $S$ and T Grades |  | -55 | +125 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature |  | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |
| Lead Temperature (10 sec max) |  |  | +300 | ${ }^{\circ} \mathrm{C}$ |

## NOTES

${ }^{1}$ 'Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ The AD779 is not designed to operate from $\pm 15 \mathrm{~V}$ supplies.

## ESD SENSITIVITY

The AD779 features input protection circuitry consisting of large "distributed" diodes and polysilicon series resistors to dissipate both high energy discharges (Human Body Model) and fast, low energy pulses (Charged Device Model). Per Method 3015.2 of MIL-STD-883C, the AD779 has been classified as a Category 1 device.
Proper ESD precautions are strongly recommended to avoid functional damage or performance degradation. Charges as high as 4000 volts readily accumulate on the human body and test equipment and discharge without detection. Unused devices must be stored in conductive foam or
 shunts, and the foam should be discharged to the destination socket before devices are removed. For further information on ESD precautions, refer to Analog Devices' ESD Prevention Manual.

ORDERING GUIDE ${ }^{1}$

| Model $^{\mathbf{2}}$ | Package | Temperature Range | Tested and Specified | Package Option |
| :--- | :--- | :--- | :--- | :--- |
| AD779JN | 28-Pin Plastic DIP | 0 to $+70^{\circ} \mathrm{C}$ | AC | N-28 |
| AD779KN | 28-Pin Plastic DIP | 0 to $+70^{\circ} \mathrm{C}$ | AC + DC | N-28 |
| AD779JD | 28-Pin Ceramic DIP | 0 to $+70^{\circ} \mathrm{C}$ | AC | D-28 |
| AD779KD | 28-Pin Ceramic DIP | 0 to $+70^{\circ} \mathrm{C}$ | AC + DC | D-28 |
| AD779AD | 28-Pin Ceramic DIP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | AC | D-28 |
| AD779BD | 28-Pin Ceramic DIP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | AC + DC | D-28 |
| AD779SD | 28-Pin Ceramic DIP | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | AC | D-28 |
| AD779TD | 28-Pin Ceramic DIP | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{AC}+$ DC | D-28 |

## NOTES

${ }^{1}$ For two cycle read ( $8+16$ bits) interface to 8 -bit buses, see AD679.
${ }^{2}$ For details on grade and package offerings screened in accordance with MIL-STD-883, refer to the Analog Devices Military Products Databook or current AD779/883B data sheet.
${ }^{3} \mathrm{D}=$ Ceramic DIP; $\mathrm{N}=$ Plastic DIP. For outline information see Package Information section.

AD779 PIN DESCRIPTION

| Symbol | 28-Pin DIP <br> Pin No. | 44-Lead JLCC Pin No. | Type | Name and Function |
| :---: | :---: | :---: | :---: | :---: |
| AGND | 7 | 11 | P | Analog Ground. This is the ground return for AIN only. |
| AIN | 6 | 10 | AI | Analog Signal Input. |
| BIPOFF | 10 | 15 | AI | Bipolar Offset. Connect to AGND for +10 V input unipolar mode and straight binary output coding. Connect to $\mathrm{REF}_{\mathrm{OUT}}$ for $\pm 5 \mathrm{~V}$ input bipolar mode and twos-complement binary output coding. |
| $\overline{\mathrm{CS}}$ | 12 | 19 | DI | Chip Select. Active LOW. |
| DGND | 14 | 23 | P | Digital Ground |
| DB13-DB0 | 28-15 | $\begin{aligned} & 43,42,40,39,37, \\ & 36,35,34,33,31, \\ & 30,27,26,25 \end{aligned}$ | DO | Data Bits. These pins provide all 14 bits in one 14 bit parallel output. Active HIGH |
| EOC | 2 | 3 | DO | End-of-Convert. EOC goes LOW when a conversion starts and goes HIGH when the conversion is finished. EOC is a three-state output. See EOCEN pin for information on EOC gating. |
| EOCEN | 13 | 21 | DI | End-of-Convert Enable. Enables EOC pin. Active LOW. |
| $\overline{\mathrm{OE}}$ | 3 | 5 | DI | Output Enable. A down-going transition on $\overline{\mathrm{OE}}$ enables data bits. Active LOW. |
| $\mathrm{REF}_{\text {IN }}$ | 9 | 14 | AI | Reference Input. +5 V input gives 10 V full scale range. |
| REF ${ }_{\text {OUT }}$ | 8 | 12 | AO | +5 V Reference Output. Tied to $\mathrm{REF}_{\text {IN }}$ for normal operation. |
| $\overline{\mathrm{SC}}$ | 4 | 6 | DI | Start Convert. Active LOW. |
| $\mathrm{V}_{\mathrm{CC}}$ | 11 | 17 | P | +12 V Analog Power. |
| $\mathrm{V}_{\text {EE }}$ | 5 | 8 | P | -12 V Analog Power. |
| $\mathrm{V}_{\text {DD }}$ | 1 | 1 | P | +5V Digital Power. |

Type: AI = Analog Input.
AO = Analog Output.
DI $=$. Digital Input.
DO = Digital Output. All DO pins are three-state drivers.
$\mathbf{P}=$ Power.

## PIN CONFIGURATION

DIP Package


FEATURES
Monolithic 12-Bit 5 MSPS A/D Converter Low Noise: 0.17 LSB RMS Referred to Input No Missing Codes Guaranteed
Differential Nonlinearity Error: 0.5 LSB
Signal-to-Noise and Distortion Ratio: 68 dB
Spurious-Free Dynamic Range: 73 dB
Power Dissipation: 1.03 W
Complete: On-Chip Track-and-Hold Amplifier and Voltage Reference
Pin Compatible with the AD872
Twos Complement Binary Output Data
Out of Range Indicator
28-Pin Ceramic DIP or 44-Pin Surface Mount Package

## PRODUCT DESCRIPTION

The AD871 is a monolithic 12 -bit, 5 Msps analog to digital converter with an on-chip, high performance track-and-hold amplifier and voltage reference. The AD871 uses a multistage differential pipelined architecture with error correction logic to provide 12 -bit accuracy at 5 Msps data rates and guarantees no missing codes over the full operating temperature range. The AD871 is a redesigned variation of the AD872 12-bit, 10 Msps ADC, optimized for lower noise in applications requiring sampling rates of 5 Msps or less. The AD871 is pin compatible with the AD872, allowing the parts to be used interchangeably as system requirements change.
The low-noise input track-and-hold (T/H) of the AD871 is ideally suited for high-end imaging applications. In addition, the T/H's high input impedance and fast settling characteristics allow the AD871 to easily interface with multiplexed systems that switch multiple signals through a single A/D converter. The dynamic performance of the input $\mathrm{T} / \mathrm{H}$ also renders the AD871 suitable for sampling single channel inputs at frequencies up to and beyond the Nyquist rate. The AD871 provides both reference output and reference input pins, allowing the on-board reference to serve as a system reference. An external reference can also be chosen to suit the dc accuracy and temperature drift requirements of the application. A single clock input is used to control all internal conversion cycles. The digital output data is presented in twos complement binary output format. An out-ofrange signal indicates an overflow condition, and can be used with the most significant bit to determine low or high overflow.

## FUNCTIONAL BLOCK DIAGRAM



The AD871 is fabricated on Analog Devices ABCMOS-1 process which utilizes high speed bipolar and CMOS transistors on a single chip. High speed, precision analog circuits are now combined with high density logic circuits.

The AD871 is packaged in a 28 -pin ceramic DIP and a 44 -pin leadless ceramic surface mount package and is specified for operation from $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ and $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.

## PRODUCT HIGHLIGHTS

The AD871 offers a complete single-chip sampling 12-bit, 5 Msps analog-to-digital conversion function in a 28 -pin DIP or 44-pin leadless ceramic surface mount package (LCC).
Low Noise-The AD871 features 0.17 LSB referred-to-input noise, producing essentially a " 1 code wide" histogram for a code-centered dc input.
Low Power-The AD871 at 1.03 W consumes a fraction of the power of presently available hybrids.
On-Chip Track-and-Hold (T/H)-The low noise, high impedance T/H input eliminates the need for external buffers and can be configured for single ended or differential inputs.
Ease of Use-The AD871 is complete with T/H and voltage reference and is pin-compatible with the AD872 (12-bit, 10 Msps monolithic ADC).
Out of Range (OTR)-The OTR output bit indicates when the input signal is beyond the AD871's input range.

## AD871 - SPECIFICATIONS

DC SPECIFICATIONS $\begin{aligned} & \left(\mathrm{T}_{\text {MIN }} \text { to } \mathrm{T}_{\text {MAX }} \text { with } \mathrm{AV}_{D D}=+5 \mathrm{~V}, D V_{D D}=+5 \mathrm{~V}, D R V_{D D}=+5 \mathrm{~V}, A V_{S S}=-5 \mathrm{~V}, \mathrm{f}_{\text {SAMPLE }}=5 \mathrm{MHz} \text { unless }\right.\end{aligned}$

| Parameter | J Grade ${ }^{1}$ | S Grade ${ }^{1}$ | Units |
| :---: | :---: | :---: | :---: |
| RESOLUTION | 12 | 12 | Bits min |
| MAX CONVERSION RATE | 5 | 5 | MHz min |
| INPUT REFERRED NOISE | 0.17 | 0.17 | LSB rms typ |
| ACCURACY <br> Integral Nonlinearity (INL) Differential Nonlinearity (DNL) No Missing Codes Zero Error (@+25응 ${ }^{2}$ Gain Error $\left(@+25^{\circ} \mathrm{C}\right)^{2}$ | $\begin{aligned} & \pm 1.5 \\ & \pm 0.5 \\ & 12 \\ & \pm 0.75 \\ & \pm 1.25 \end{aligned}$ | $\begin{aligned} & \pm 1.5 \\ & \pm 0.5 \\ & 12 \\ & \pm 0.75 \\ & \pm 1.25 \end{aligned}$ | LSB typ <br> LSB typ <br> Bits Guaranteed <br> \% FSR max <br> \% FSR max |
|  | $\begin{aligned} & \pm 0.15 \\ & \pm 0.80 \\ & \pm 0.25 \end{aligned}$ | $\begin{aligned} & \pm 0.3 \\ & \pm 1.75 \\ & \pm 0.50 \end{aligned}$ | \% FSR max <br> \% FSR max <br> \% FSR max |
| POWER SUPPLY REJECTION ${ }^{6}$ $\begin{aligned} & \mathrm{AV}_{\mathrm{DD}}, \mathrm{DV}_{\mathrm{DD}}(+5 \mathrm{~V} \pm 0.25 \mathrm{~V}) \\ & \mathrm{AV}_{\mathrm{ss}}(-5 \mathrm{~V} \pm 0.25 \mathrm{~V}) \end{aligned}$ | $\begin{aligned} & \pm 0.125 \\ & \pm 0.125 \end{aligned}$ | $\begin{aligned} & \pm 0.125 \\ & \pm 0.125 \end{aligned}$ | \% FSR max <br> \% FSR max |
| ANALOG INPUT <br> Input Range Input Resistance Input Capacitance | $\begin{aligned} & \pm 1 \\ & 50 \\ & 10 \end{aligned}$ | $\begin{aligned} & \pm 1 \\ & 50 \\ & 10 \end{aligned}$ | Volts max <br> $\mathrm{k} \Omega$ typ <br> pF typ |
| INTERNAL VOLTAGE REFERENCE <br> Output Voltage <br> Output Voltage Tolerance <br> Output Current (Available for External Loads) <br> (External load should not change during conversion.) | $\begin{aligned} & 2.5 \\ & \pm 20 \\ & 2.0 \end{aligned}$ | $\begin{aligned} & 2.5 \\ & \pm 40 \\ & 2.0 \end{aligned}$ | Volts typ <br> mV max <br> mA typ |
| REFERENCE INPUT RESISTANCE | 5 | 5 | $\mathrm{k} \Omega$ typ |
| ```POWER SUPPLIES Supply Voltages \(A V_{D D}\) \(\mathrm{AV}_{\text {Ss }}\) \(\mathrm{DV}_{\text {DD }}\) \(\mathrm{DRV}_{\mathrm{DD}}{ }^{7}\) Supply Current \(I A V_{D D}\) \(\mathrm{IAV}_{\text {ss }}\) IDV \(_{\text {DD }}\) \(\operatorname{IDRV}_{\text {DD }}{ }^{7}\)``` | $\begin{aligned} & +5 \\ & -5 \\ & +5 \\ & +5 \\ & \\ & 87 \\ & 147 \\ & 20 \\ & 2 \end{aligned}$ | $\begin{aligned} & +5 \\ & -5 \\ & +5 \\ & +5 \\ & \\ & 88 \\ & 150 \\ & 21 \\ & 2 \end{aligned}$ | $\mathrm{V}\left( \pm 5 \% \mathrm{AV}_{\mathrm{DD}}\right.$ Operating) <br> $\mathrm{V}\left( \pm 5 \% \mathrm{AV}_{\text {ss }}\right.$ Operating $)$ <br> $\mathrm{V}\left( \pm 5 \% \mathrm{DV}_{\mathrm{DD}}\right.$ Operating) <br> $\mathrm{V}\left( \pm 5 \% \mathrm{DRV}_{\mathrm{DD}}\right.$ Operating) <br> $m A \max (82 \mathrm{~mA} \operatorname{typ})$ <br> $\mathrm{mA} \max (115 \mathrm{~mA}$ typ $)$ <br> $m A \max (7 \mathrm{~mA}$ typ) <br> $m A$ max |
| POWER CONSUMPTION | $\begin{aligned} & 1.03 \\ & 1.25 \end{aligned}$ | $\begin{aligned} & 1.03 \\ & 1.3 \end{aligned}$ | W typ <br> W max |

## NOTES

${ }^{1}$ Temperature ranges are as follows: J Grade: $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}, \mathrm{S}$ Grade: $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
${ }^{2}$ Adjustable to zero with external potentiometers (see Zero and Gain Error Calibration section).
${ }^{3}+25^{\circ} \mathrm{C}$ to $\mathrm{T}_{\text {MIN }}$ and $+25^{\circ} \mathrm{C}$ to $\mathrm{T}_{\text {MAX }}$.
${ }^{4}$ Includes internal voltage reference error.
${ }^{5}$ Excludes internal reference drift.
${ }^{6}$ Change in Gain Error as a function of the dc supply voltage ( $V$ nominal to V min, V nominal to V max).
${ }^{7}$ LCC package only.
Specifications subject to change without notice.

GPECFA

|  | J Grade | S Grade | Units |
| :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { SIGNAL-TO-NOISE AND DISTORTION RATIO }(\mathrm{S} / \mathrm{N}+\mathrm{D}) \\ & \mathrm{f}_{\text {INPUT }}=750 \mathrm{kHz} \\ & \mathrm{f}_{\mathrm{INPUT}}=1 \mathrm{MHz} \\ & \\ & \mathrm{f}_{\text {INPUT }}=2.49 \mathrm{MHz} \end{aligned}$ | $\begin{aligned} & 68 \\ & 66 \\ & 63 \\ & 60 \end{aligned}$ | $\begin{aligned} & 68 \\ & 66 \\ & 62 \\ & 60 \end{aligned}$ | dB typ dB typ dB min dB typ |
| TOTAL HARMONIC DISTORTION (THD) $\begin{aligned} & \mathrm{f}_{\text {INPUT }}=750 \mathrm{kHz} \\ & \mathrm{f}_{\text {INPUT }}=1 \mathrm{MHz} \\ & \mathrm{f}_{\text {INPUT }}=2.49 \mathrm{MHz} \end{aligned}$ | $\begin{aligned} & -72 \\ & -69 \\ & -64 \\ & -62 \end{aligned}$ | $\begin{aligned} & -72 \\ & -69 \\ & -63 \\ & -62 \end{aligned}$ | dB typ dB typ dB max dB typ |
| SPURIOUS FREE DYNAMIC RANGE (SFDR) $\begin{aligned} & \mathrm{f}_{\text {INPUT }}=750 \mathrm{kHz} \\ & \mathrm{f}_{\text {INPUT }}=1 \mathrm{MHz} \\ & \mathrm{f}_{\text {INPUT }}=2.49 \mathrm{MHz} \end{aligned}$ | $\begin{aligned} & 73 \\ & 70 \\ & 62 \end{aligned}$ | $\begin{aligned} & 73 \\ & 70 \\ & 62 \end{aligned}$ | dB typ dB typ dB typ |
| INTERMODULATION DISTORTION (IMD) ${ }^{2}$ <br> Second Order Products <br> Third Order Products | $\begin{aligned} & -80 \\ & -73 \end{aligned}$ | $\begin{aligned} & -80 \\ & -73 \end{aligned}$ | dB typ dB typ |
| FULL POWER BANDWIDTH | 15 | 15 | MHz typ |
| SMALL SIGNAL BANDWIDTH | 15 | 15 | MHz typ |
| APERTURE DELAY | 6 | 6 | ns typ |
| APERTURE JITTER | 16 | 16 | ps rms typ |
| ACQUISITION TO FULL-SCALE STEP | 80 | 80 | ns typ |
| OVERVOLTAGE RECOVERY TIME | 80 | 80 | ns typ |

NOTES
${ }^{1} \mathrm{f}_{\mathrm{IN}}$ amplitude $=-0.5 \mathrm{~dB}$ full scale unless otherwise indicated. All measurements referred to a $0 \mathrm{~dB}(1 \mathrm{~V} \mathrm{pk})$ input signal unless otherwise indicated.
${ }^{2} \mathrm{fa}=1.0 \mathrm{MHz}, \mathrm{fb}=0.95 \mathrm{MHz}$ with $\mathrm{f}_{\text {SAMPLE }}=5 \mathrm{MHz}$.
Specifications subject to change without notice.
DIGITAL SPECIFICATIONS ( $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ with $\mathrm{AV}_{D D}=+5 \mathrm{~V}, \mathrm{DV}_{D D}=+5 \mathrm{~V}, \mathrm{AV}_{S S}=-5 \mathrm{~V}$ unless otherwise noted)

| Parameter | Symbol | J, S Grades | Units |
| :---: | :---: | :---: | :---: |
| LOGIC INPUTS |  |  |  |
| High Level Input Voltage | $\mathrm{V}_{\text {IH }}$ | +2.0 | $V$ min |
| Low Level Input Voitage | $\mathrm{V}_{\text {IL }}$ | +0.8 | V max |
| High Level Input Current ( $\mathrm{V}_{\mathrm{IN}}=\mathrm{DV}_{\mathrm{DD}}$ ) | $\mathrm{I}_{\mathrm{IH}}$ | $\pm 10$ | $\mu \mathrm{A}$ max |
| Low Level Input Current ( $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ ) | $\mathrm{I}_{\text {IL }}$ | $\pm 10$ | $\mu \mathrm{A}$ max |
| Input Capacitance | $\mathrm{C}_{\text {IN }}$ | 5 | pF typ |
| LOGIC OUTPUTS |  |  |  |
| High Level Output Voltage ( $\mathrm{I}_{\mathrm{OH}}=0.5 \mathrm{~mA}$ ) | $\mathrm{V}_{\mathrm{OH}}$ | +2.4 | $V$ min |
| Low Level Output Voltage ( $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ ) | $\mathrm{V}_{\mathrm{OL}}$ | +0.4 | $V$ max |
| Output Capacitance | $\mathrm{C}_{\text {Out }}$ | 5 | pF typ |
| Leakage (Three-State, LCC Only) | IZ | $\pm 10$ | $\mu \mathrm{A}$ max |

Specifications subject to change without notice.

SWITCHNG SPECIFICATIONS ${ }_{V}^{\left(T_{M I N}\right.}$ to $T_{M A X}$ with $\mathrm{VV}_{D D}=+5 \mathrm{~V}, D V_{D D}=+5 \mathrm{~V}, D R V_{D D}=+5 \mathrm{~V}, \mathrm{AV}_{S S}=-5 \mathrm{~V}$; $V_{I L}=0.8 \mathrm{~V}$,

| Parameter | Symbol | J, S Grades | Units |
| :---: | :---: | :---: | :---: |
| Clock Period ${ }^{1}$ | $\mathrm{t}_{\mathrm{c}}$ | 200 | ns min |
| CLOCK Pulse Width High | $\mathrm{t}_{\mathrm{CH}}$ | 95 | ns min |
| CLOCK Pulse Width Low | $\mathrm{t}_{\mathrm{CL}}$ | 95 | ns min |
| Clock Duty Cycle ${ }^{2}$ |  | 40 | \% min (50\% typ) |
|  |  | 60 | \% max |
| Output Delay | $t_{\text {OD }}$ | 10 | ns $\min$ ( 20 ns typ ) |
| Pipeline Delay (Latency) |  | 3 | Clock Cycles |
| Data Access Time (LCC Package Only) ${ }^{3}$ | $\mathrm{t}_{\text {DD }}$ | 50 | ns typ ( 100 pF Load) |
| Output Float Delay (LCC Package Only) ${ }^{3}$ | $\mathrm{t}_{\mathrm{HL}}$ | 50 | ns typ (10 pF Load) |

## NOTES

${ }^{1}$ Conversion rate is operational down to 10 kHz without degradation in specified performance.
${ }^{2}$ For clock periods of 200 ns or greater, see Clock Input Section.
${ }^{3}$ See Section on Three-State Outputs for timing diagrams and application information.
Specifications subject to change without notice.


Figure 1. Timing Diagram

ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

| Parameter | With Respect to | Min | Max | Units |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{AV}_{\text {DD }}$ | AGND | -0.5 | +6.5 | Volts |
| $\mathrm{AV}_{\text {S }}$ | AGND | -6.5 | +0.5 | Volts |
| DV ${ }_{\text {DD }}, \mathrm{DRV}_{\text {DD }}$ | DGND, DRGND | -0.5 | +6.5 | Volts |
| $\mathrm{DRV}^{\text {DD }}{ }^{2}$ | DV ${ }_{\text {DD }}$ | -6.5 | +6.5 | Volts |
| DRGND ${ }^{2}$ | DGND | -0.3 | +0.3 | Volts |
| AGND | DGND | -1.0 | +1.0 | Volts |
| $\mathrm{AV}_{\text {DD }}$ | $\mathrm{DV}_{\text {DD }}$ | -6.5 | +6.5 | Volts |
| Clock Input, OEN | DGND | -0.5 | DV ${ }_{\text {DD }}+0.5$ | Volts |
| Digital Outputs | DGND | -0.5 | DV ${ }_{\text {DD }}+0.3$ | Volts |
| $\mathrm{V}_{\mathrm{INA}}, \mathrm{~V}_{\text {INB }} \text { REF IN }$ | AGND | $-6.5$ | $+6.5$ | Volts |
| REF IN | AGND | $\mathrm{AV}_{\text {SS }}$ | $\mathrm{AV}_{\text {DD }}$ | Volts |
| Junction Temperature |  |  | +150 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature |  | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |
| Lead Temperature (10 sec) |  |  | $+300$ | ${ }^{\circ} \mathrm{C}$ |

[^17]PIN DESCRIPTION

| Symbol | DIP <br> Pin No. | LCC <br> Pin No. | Type | Name and Function |
| :---: | :---: | :---: | :---: | :---: |
| AGND | 5, 24 | 9, 36 | P | Analog Ground. |
| $\mathrm{AV}_{\text {DD }}$ | 4 | 6, 38 | P | +5 V Analog Supply. |
| $\mathrm{AV}_{\text {ss }}$ | 3, 25 | 5, 40 | P | -5 V Analog Supply. |
| $\overline{\text { MSB }}$ | 19 | 29 | DO | Inverted Most Significant Bit. Provides twos complement output data format. |
| MSB | N/A | 27 | DO | Most Significant Bit. |
| BIT 2-BIT 11 | 18-9 | 26-17 | DO | Data Bits 2 through 11. |
| BIT 12 (LSB) | 8 | 16 | DO | Least Significant Bit. |
| CLK | 21 | 31 | DI | Clock Input. The AD871 will initiate a conversion on the rising edge of the clock input. See the Timing Diagram for details. |
| DV ${ }_{\text {DD }}$ | 7, 22 | 33 | P | +5 V Digital Supply. |
| DGND | 6, 23 | 10 | P | Digital Ground. |
| $\mathrm{DRV}_{\text {DD }}$ | N/A | 12, 32 | P | +5 V Digital Supply for the output drivers. |
| DRGND | N/A | 11, 34 | P | Digital Ground for the output drivers. (See section on Power Supply Decoupling for details on $\mathrm{DRV}_{\mathrm{DD}}$ and DRGND.) |
| OTR | 20 | 30 | DO | Out of Range is Active HIGH on the leading edge of code 0 or the trailing edge of code 4096. See Output Data Format Table III. |
| OEN | N/A | 13 | DI | Output Enable. See the Three State Output Timing Diagram for details. |
| REF GND | 27 | 42 | AI | Reference Ground. |
| REF IN | 28 | 43 | AI | Reference Input. +2.5 V input gives $\pm 1 \mathrm{~V}$ full-scale range. |
| REF OUT | 26 | 41 | AO | +2.5 V Reference Output. Tie to REF IN for normal operation. |
| $\mathrm{V}_{\text {INA }}$ | 1 | 1 | AI | (+) Analog Input Signal on the differential input amplifier. |
| $\mathrm{V}_{\text {INB }}$ | 2 | 2 | AI | $(-)$ Analog Input Signal on the differential input amplifier. |
| NC | N/A | $\begin{aligned} & 3,4,7,8,14,15, \\ & 28,35,37,39,44 \end{aligned}$ |  | No Connect. |

TYPE: AI = Analog Input; AO = Analog Output; DI = Digital Input; DO = Digital Output; P = Power; N/A = Not Available on 28-pin DIP. Only available on 44-pin surface mount package.

## PIN CONFIGURATIONS

28-Pin Ceramic DIP


44-Pin LCC


## AD871

## DEFINITIONS OF SPECIFICATIONS LINEARITY ERROR

Linearity error refers to the deviation of each individual code from a line drawn from "negative full scale" through "positive full scale." The point used as "negative full scale" occurs $1 / 2$ LSB before the first code transition. "Positive full scale" is defined as a level $11 / 2$ LSB beyond the last code transition. The deviation is measured from the middle of each particular code to the true straight line.

## DIFFERENTIAL LINEARITY ERROR (DNL, NO MISSING CODES)

An ideal ADC exhibits code transitions that are exactly 1 LSB apart. DNL is the deviation from this ideal value. Guaranteed no missing codes to 12 -bit resolution indicates that all 4096 codes must be present over all operating ranges.

## ZERO ERROR

The major carry transition should occur for an analog value $1 / 2$ LSB below analog common. Zero error is defined as the deviation of the actual transition from that point. The zero error and temperature drift specify the initial deviation and maximum change in the zero error over temperature.

## GAIN ERROR

The first code transition should occur for an analog value $1 / 2$ LSB above nominal negative full scale. The last transition should occur for an analog value $11 / 2$ LSB below the nominal positive full scale. Gain error is the deviation of the actual difference between first and last code transitions and the ideal difference between first and last code transitions.

## TEMPERATURE DRIFT

The temperature drift for zero error and gain error specifies the maximum change from the initial $\left(25^{\circ} \mathrm{C}\right)$ value to the value at $\mathrm{T}_{\text {MIN }}$ or $\mathrm{T}_{\text {MAX }}$.

## POWER SUPPLY REJECTION

The specifications show the maximum change in the converter's full-scale as the supplies are varied from nominal to $\mathrm{min} / \mathrm{max}$ values.

## APERTURE JITTER

Aperture jitter is the variation in aperture delay for successive samples and is manifested as noise on the input to the A/D.

## APERTURE DELAY

Aperture delay is a measure of the Track-and-Hold Amplifier (THA) performance and is measured from the rising edge of the clock input to when the input signal is held for conversion.

## OVERVOLTAGE RECOVERY TIME

Overvoltage recovery time is defined as that amount of time required for the ADC to achieve a specified accuracy after an overvoltage ( $50 \%$ greater than full-scale range), measured from the time the overvoltage signal reenters the converter's range.

## DYNAMIC SPECIFICATIONS

SIGNAL-TO-NOISE AND DISTORTION (S/N+D) RATIO $\mathrm{S} / \mathrm{N}+\mathrm{D}$ is the ratio of the rms value of the measured input signal to the rms sum of all other spectral components below the Nyquist frequency, including harmonics but excluding dc. The value for $\mathrm{S} / \mathrm{N}+\mathrm{D}$ is expressed in decibels.

## TOTAL HARMONIC DISTORTION (THD)

THD is the ratio of the rms sum of the first six harmonic components to the rms value of the measured input signal and is expressed as a percentage or in decibels.

## INTERMODULATION DISTORTION (IMD)

With inputs consisting of sine waves at two frequencies, fa and fb , any device with nonlinearities will create distortion products, of order ( $\mathrm{m}+\mathrm{n}$ ), at sum and difference frequencies of $\mathrm{mfa} \pm \mathrm{nfb}$, where $\mathrm{m}, \mathrm{n}=0,1,2,3 \ldots$ Intermodulation terms are those for which $m$ or $n$ is not equal to zero. For example, the second order terms are $(\mathrm{fa}+\mathrm{fb})$ and $(\mathrm{fa}-\mathrm{fb})$, and the third order terms are $(2 \mathrm{fa}+\mathrm{fb}),(2 \mathrm{fa}-\mathrm{fb}),(\mathrm{fa}+2 \mathrm{fb})$ and ( $2 \mathrm{fb}-\mathrm{fa}$ ). The IMD products are expressed as the decibel ratio of the rms sum of the measured input signals to the rms sum of the distortion terms. The two signals are of equal amplitude and the peak value of their sums is -0.5 dB from full scale. The IMD products are normalized to a 0 dB input signal.

## FULL-POWER BANDWIDTH

The full-power bandwidth is that input frequency at which the amplitude of the reconstructed fundamental is reduced by 3 dB for a full-scale input.

## SPURIOUS FREE DYNAMIC RANGE

The difference, in dB , between the rms amplitude of the input signal and the peak spurious signal.

ORDERING GUIDE

| Model | Temperature Range | Package Option ${ }^{1,2}$ |
| :--- | :--- | :--- |
| AD871JD | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{D}-28$ |
| AD871JE | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | E-44A |
| AD871SD $^{3}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | D-28 |
| AD871SE $^{3}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | E-44A |

## NOTES

${ }^{1} \mathrm{D}=$ Ceramic DIP, $\mathrm{E}=$ Leadless Ceramic Chip Carrier.
${ }^{2}$ For outline information see Package Information section.
${ }^{3}$ MIL-STD-883 version will be available; contact factory.

# Dynamic Characteristics-Sampie Rate: 5 MSPS—AD871 



Figure 2. $A D 871 S /(N+D)$ vs. Input Frequency


Figure 3. AD871 Distortion vs. Input Frequency, Full-Scale Input


Figure 4. AD871 Typical FFT, $f_{I N}=1 \mathrm{MHz}, f_{I N}$ Amplitude $=-0.5 d B$


Figure 5. AD871 Typical FFT, $f_{I N}=1 \mathrm{MHz}, f_{I N}$ Amplitude $=-6 d B$


Figure 6. AD871 Typical FFT, $f_{I N}=750 \mathrm{kHz}$


Figure 7. AD871 Typical FFT, $f_{I_{N}}=2 \mathrm{MHz}$


Figure 8. AD871 Output Code Histogram for DC input


Figure 9. AD871 Code Probability at a Transition

## THEORY OF OPERATION

The AD871 is implemented using a 4 -stage pipelined multiple flash architecture. A differential input track-and-hold amplifier (THA) acquires the input and converts the input voltage into a differential current. A 4-bit approximation of the input is made by the first flash converter, and an accurate analog representation of this 4 -bit guess is generated by a digital-to-analog converter. This approximation is subtracted from the THA output to produce a remainder, or residue. This residue is then sampled and held by the second THA, and a 4-bit approximation is generated and subtracted by the second stage. Once the second THA goes into hold, the first stage goes back into track to acquire a new input signal. The third stage provides a 3 -bit approximation/subtraction operation, and produces the final residue, which is passed to a final 4-bit flash converter. The 15 output bits from the 4 flash converters are accumulated in the correction logic block, which adds the bits together using the appropriate correction algorithm, to produce the 12 -bit output word. The digital output, together with overrange indicator, is latched into an output buffer to drive the output pins.
The additional THA inserted in each stage of the AD871 architecture allows pipelining of the conversion. In essence, the converter is converting multiple inputs simultaneously, processing them through the converter chain serially. This means that while the converter is capable of capturing a new input sample every clock cycle, it actually takes three clock cycles for the conversion to be fully processed and appear at the output. This "pipeline delay" is often referred to as latency, and is not a concern in most applications, however there are some cases where it may be a consideration. For example, some applications call for the A/D converter to be placed in a high speed feedback loop, where its input is servoed to provide a desired result at the digital output (e.g., offset calibration or zero restoration in video applications). In these cases the 3 clock cycle delay through the pipeline must be accounted for in the loop stability calculations. Also, because the converter is working on three conversions simultaneously, major disruptions to the part (such as a large glitch on the supplies or reference) may corrupt three data samples. Finally, there will be a minimum clock rate below which the THA droop corrupts the signal in the pipeline. In the case of the AD871, this minimum clock rate is 10 kHz .
The high impedance differential inputs of the AD871 allow a variety of input configurations (see APPLYING THE AD871). The AD871 converts the voltage difference between the $\mathrm{V}_{\text {INA }}$ and $\mathrm{V}_{\text {INB }}$ pins. For single-ended applications, one input pin ( $\mathrm{V}_{\text {INA }}$ or $\mathrm{V}_{\text {INB }}$ ) may be grounded, but even in this case the differential input can provide a performance boost: for example, for an input coming from a coaxial cable, $\mathrm{V}_{\text {INB }}$ can be tied to the shield ground, allowing the AD871 to reject shield noise as common mode. The high input impedance of the device minimizes external driving requirements and allows the user to externally select the appropriate termination impedance for the application.
The AD871 clock circuitry uses both edges of the clock in its internal timing circuitry (see spec page for exact timing requirements.) The AD871 samples the analog input on the rising edge of the clock input. During the clock low time (between the falling edge and rising edge of the clock) the input THA is in track mode; during the clock high time it is in hold. System disturbances just prior to the rising edge of the clock may cause the part to acquire the wrong value, and should be minimized.

While the part uses both clock edges for its timing, jitter is only a significant issue for the rising edge of the clock (see CLOCK INPUT section).

## APPLYING THE AD871 ANALOG INPUTS

The AD871 features a high impedance differential input that can readily operate on either single-ended or differential input signals. Table I summarizes the nominal input voltage span for both single-ended and differential modes, assuming a 2.5 V reference input.

Table I. Input Voltage Span

|  | $\mathbf{V}_{\text {INA }}$ | $\mathbf{V}_{\text {INB }}$ | $\mathbf{V}_{\mathbf{I N A}}-\mathbf{V}_{\mathbf{I N B}}$ |
| :--- | :--- | :--- | :--- |
| Single-Ended | +1 V | GND | +1 V (Positive Full Scale) |
|  | -1 V | GND | -1 V (Negative Full Scale) |
| Differential | +0.5 V | -0.5 V | +1 V (Positive Full Scale) |
|  | -0.5 V | +0.5 V | -1 V (Negative Full Scale) |

Figure 10 shows an approximate model for the analog input circuit. As this model indicates, when the input exceeds 1.6 V (with respect to AGND), the input device may saturate, causing the input impedance to drop substantially and significantly reducing the performance of the part. Input compliance in the negative direction is somewhat larger, showing virtually no degradation in performance for inputs as low as -1.9 V .


Figure 10. AD871 Equivalent Analog Input Circuit
Figure 11 illustrates the effect of varying the common-mode voltage of a -0.5 dB input signal on total harmonic distortion.


Figure 11. AD871 Total Harmonic Distortion vs. CM Input Voltage, $f_{I N}=1 \mathrm{MHz}, F S=5 \mathrm{MSPS}$

Figure 12 shows the common-mode rejection performance vs. frequency for a 1 V p-p common mode input. This excellent common-mode rejection over a wide bandwidth affords the user the opportunity to eliminate many potential sources of input noise as common mode by using the differential input structure of the AD871.


Figure 12. Common-Mode Rejection vs. Input Frequency, 1 V p-p Input

Figures 13 and 14 illustrate typical input connections for singleended inputs.


Figure 13. AD871 Single-Ended Input Connection


Figure 14. AD871 Single-Ended Input Connection Using a Shielded Cable

The cable shield is used as the ground connection for the $\mathrm{V}_{\text {INB }}$ input, providing the best possible rejection of the cable noise from the input signal. Note also that the high input impedance of the AD871 allows the user to select the termination impedance, be it 50 ohms, 75 ohms, or some other value. Furthermore, unlike many flash converters, most AD871 applications will not require an external buffer amplifier. If such an amplifier is required, we suggest either the AD811 or AD9617.

Figure 15 illustrates how external amplifiers may be used to convert a single-ended input into a differential signal. The resistor values of $536 \Omega$ and $562 \Omega$ were selected to provide optimum phase matching between U 1 and U 2 .


Figure 15. Single-Ended to Differential Connections; U1, U2 = AD811 or AD9617

The use of the differential input signal can help to minimize even-order distortion from the input THA where performance beyond -70 dB is desired.

Figure 16 shows the AD871 large signal ( -0.5 dB ) and small signal ( -20 dB ) frequency response.


Figure 16. Full Power ( $-0.5 d B$ ) and Small Signal Response ( -20 dB ) vs. Input Frequency

The AD871's wide input bandwidth facilitates rapid acquisition of transient input signals: the input THA can typically settle to 12-bit accuracy from a full-scale input step in less than 80 ns . Figure 17 illustrates the typical acquisition of a full-scale input step.


Figure 17. Typical AD871 Settling Time

The wide input bandwidth and superior dynamic performance of the input THA make the AD871 suitable for sampling inpי at frequencies up to the Nyquist Rate. The input THA is designed to recover rapidly from input overdrive conditions, returning from a $50 \%$ overdrive in less than 100 ns .
Because of the THA's exceptionally wide input bandwidth, some users may find the AD871 is sensitive to noise at frequencies from 10 MHz to 50 MHz that other converters are incapable of responding to. This sensitivity can be mitigated by careful use of the differential inputs (see previous paragraphs). Additionally, Figure 18 shows how a small capacitor ( $10 \mathrm{pF}-20 \mathrm{pF}$ for $50 \Omega$ terminated inputs) may be placed between $V_{\text {INA }}$ and $\mathrm{V}_{\text {INB }}$ to help reduce high frequency noise in applications where limiting the input bandwidth is acceptable.


Figure 18. Optional High Frequency Noise Reduction
The AD871 will contribute its own wideband thermal noise. As a result of the integrated wideband noise ( 0.17 LSB rms, referred-to-input), applying a dc analog input may produce more than one code at the output. A histogram of the ADC output codes, for a dc input voltage, will be between 1 and 3 codes wide, depending on how well the input is centered on a given code and how many samples are taken. Figure 8 shows a typical AD871 code histogram, and Figure 9 illustrates the AD871's transition noise.

## REFERENCE INPUT

The nominal reference input should be 2.5 V , taken with respect to REFERENCE GROUND (REF GND). Figure 19 illustrates the equivalent model for the reference input: there is no clock or signal-dependent activity associated with the reference input circuitry, therefore, no "kickback" into the reference.


Figure 19. Equivalent Reference Input Circuit
However, in order to realize the lowest noise performance of the AD871, care should be taken to minimize noise at the reference input.

The AD871's reference input impedance is equal to $5 \mathrm{k} \Omega$ ( $\pm 20 \%$ ), and its effective noise bandwidth is 10 MHz , with a referred-to-input noise gain of 0.8 . For example, the internal reference, with an rms noise of $28 \mu \mathrm{~V}$ (using an external $1 \mu \mathrm{~F}$ capacitor), contributes $24 \mu \mathrm{~V}(0.05 \mathrm{LSB})$ of noise to the transfer function of the AD871.
The full-scale peak-to-peak input voltage is a function of the reference voltage, according to the equation:

$$
\left(V_{I N A}-V_{I N B}\right) \text { Full Scale }=0.8^{\star}\left(V_{R E F}-R E F G N D\right)
$$

Note that the AD871's performance was optimized for a 2.5 V reference input: performance may degrade somewhat for other reference voltages. Figure 20 illustrates the $\mathrm{S} /(\mathrm{N}+\mathrm{D})$ performance vs. reference voltage for a $1 \mathrm{MHz},-0.5 \mathrm{~dB}$ input signal. Note also that if the reference is changed during a conversion, all three conversions in the pipeline will be invalidated.


Figure 20. $S /(N+D)$ vs. Reference Input Voltage, $f_{I N}=1 \mathrm{MHz}, F S=5 \mathrm{MHz}$

Table II summarizes various 2.5 V references suitable for use with the AD871, including the onboard bandgap reference (see REFERENCE OUTPUT section).

Table II. Suitable 2.5 V References

|  | Drift $\left(\mathbf{P P M} /{ }^{\circ} \mathrm{C}\right)$ | Initial Accuracy \% |
| :--- | :---: | :---: |
| REF-43B | 6 (max) | 0.2 |
| AD680JN | $10(\mathrm{max})$ | 0.4 |
| Internal | $30($ typ $)$ | 0.4 |

If an external reference is connected to REF IN, REF OUT must be connected to +5 V . This should lower the current in REF GND to less than $350 \mu \mathrm{~A}$ and eliminate the need for a $1 \mu \mathrm{~F}$ capacitor, although decoupling the reference for noise reduction purposes is recommended.
Alternatively, Figure 21 shows how the AD871 may be driven from other references by use of an external resistor. The external resistor forms a resistor divider with the on-chip $5 \mathrm{k} \Omega$ resistor to realize 2.5 V at the reference input pin (REF IN). A trim potentiometer is needed to accommodate the tolerance of the AD871's $5 \mathrm{k} \Omega$ resistor.


Figure 21. Optional +5 V Reference Input Circuit

## REFERENCE GROUND

The REF GND pin provides the reference point for both the reference input, and the reference output. When the internal reference is operating, it will draw approximately $500 \mu \mathrm{~A}$ of current through the reference ground, so a low impedance path to the external common is desirable. The AD871 can tolerate a fairly large difference between REF GND and AGND, up to $\pm 1 \mathrm{~V}$, without any performance degradation.

## REFERENCE OUTPUT

The AD871 features an onboard, curvature compensated bandgap reference that has been laser trimmed for both absolute value and temperature drift. The output stage of the reference was designed to allow the use of an external capacitor to limit the wideband noise. As Figure 22 illustrates, a $1 \mu F$ capacitor on the reference output is required for stability of the reference output buffer. Note: If used, an external reference may become unstable with this capacitor in place.


Figure 22. Typical Reference Decoupling Connection
With this capacitor in place, the noise on the reference output is approximately $28 \mu \mathrm{~V}$ rms at room temperature. Figure 23 shows the typical temperature drift performance of the reference, while Figure 24 illustrates the variation in reference voltage with load currents.
The output stage is designed to provide at least 2 mA of output current, allowing a single reference to drive up to four AD871s, or other external loads. The power supply rejection of the reference is better than 54 dB at dc.


Figure 23. Reference Output Voltage vs. Temperature


Figure 24. Reference Output Voltage vs. Output Load

## DIGITAL OUTPUTS

In 28-pin packages, the AD871 output data is presented in twos complement format. Table III indicates offset binary and twos complement output for various analog inputs.

Table III. Output Data Format

| Analog Input | Digital Output |  |  |  |
| :--- | :--- | :--- | :--- | :---: |
| $\mathbf{V}_{\text {INA }}-\mathbf{V}_{\text {INB }}$ | Offset Binary |  | Twos Complement |  |
| $\geq 0.999756 \mathrm{~V}$ | 111111111111 | 011111111111 | 1 |  |
| 0.999268 V | 111111111111 | 011111111111 | 0 |  |
| 0 V | 100000000000 | 000000000000 | 0 |  |
| -1 V | 000000000000 | 100000000000 | 0 |  |
| -1.000244 V | 000000000000 | 100000000000 | 1 |  |

Users requiring offset binary encoding may simply invert the $\overline{\text { MSB }}$ pin. In the 44-pin surface mount packages, both MSB and $\overline{\text { MSB }}$ bits are provided.

The AD871 features a digital out-of-range (OTR) bit that goes high when the input exceeds positive full scale or falls below negative full scale. As Table III indicates, the output bits will be set appropriately according to whether it is an out-of-range high condition or an out-of-range low condition. Note that if the input is driven beyond +1.5 V , the digital outputs may not stay at +FS , but may actually fold back to midscale.

The AD871's CMOS digital output drivers are sized to provide sufficient output current to drive a wide variety of logic families. However, large drive currents tend to cause glitches on the supplies and may affect $\mathrm{S} /(\mathrm{N}+\mathrm{D})$ performance. Applications requiring the AD871 to drive large capacitive loads or large fanout may require additional decoupling capacitors on $\mathrm{DRV}_{\mathrm{DD}}$ and $\mathrm{DV}_{\mathrm{DD}}$. In extreme cases, external buffers or latches could be used.

## THREE-STATE OUTPUTS

The 44-pin surface mount AD871 offers three-state outputs. The digital outputs can be placed into a three-state mode by pulling the OUTPUT ENABLE (OEN) pin LOW. Note that this function is not intended to be used to pull the AD871 on and off a bus at 5 MHz . Rather, it is intended to allow the ADC to be pulled off the bus for evaluation or test modes. Also, to avoid corruption of the sampled analog signal during conversion ( 3 clock cycles), it is highly recommended that the AD871 be placed on the bus prior to the first sampling.


Figure 25. Three-State Output Timing Diagram
For timing budgetary purposes, the typical access and float delay times for the AD871 are 50 ns.

## CLOCK INPUT

The AD871 internal timing control uses the two edges of the clock input to generate a variety of internal timing signals. The optimal clock input should have a $50 \%$ duty cycle; however, sensitivity to duty cycle is significantly reduced for clock rates of less than 5 megasamples per second.


Figure 26. Divide-by-Two Clock Circuit
Due to the nature of on-chip compensation circuitry, the duty cycle should be maintained between $40 \%$ and $60 \%$ even for clock rates less than 5 Msps . One way to realize a $50 \%$ duty cycle clock is to divide down a clock of higher frequency, as shown in Figure 26.
In this case, a 10 MHz clock is divided by 2 to produce the 5 MHz clock input for the AD871. In this configuration, the duty cycle of the 10 MHz clock is irrelevant.

The input circuitry for the CLKIN pin is designed to accommodate both TTL and CMOS inputs. The quality of the logic input, particularly the rising edge, is critical in realizing the best possible jitter performance for the part: the faster the rising edge, the better the jitter performance.
As a result, careful selection of the logic family for the clock driver, as well as the fanout and capacitive load on the clock line, is important. Jitter-induced errors become more pronounced at higher frequency, large amplitude inputs, where the input slew rate is greatest.
The AD871 is designed to support a sampling rate of 5 Msps ; running at slightly faster clock rates may be possible, although at reduced performance levels. Conversely, some slight performance improvements might be realized by clocking the AD871 at slower clock rates. Figure 27 presents the $\mathrm{S} /(\mathrm{N}+\mathrm{D})$ vs. clock frequency for a 1 MHz analog input.


Figure 27. Typical $S /(N+D)$ vs. Clock Frequency $f_{I N}=1 \mathrm{MHz}$, Full-Scale Input

The power dissipated by the correction logic and output buffers is largely proportional to the clock frequency; running at reduced clock rates provides a slight reduction in power consumption. Figure 28 illustrates this tradeoff.


Figure 28. Typical Power Dissipation vs. Clock Frequency

## ANALOG SUPPLIES AND GROUNDS

The AD871 features separate analog and digital supply and ground pins, helping to minimize digital corruption of sensitive analog signals. In general, $\mathrm{AV}_{\mathrm{SS}}$ and $\mathrm{AV}_{\mathrm{DD}}$, the analog supplies,
should be decoupled to AGND, the analog common, as close to the chip as physically possible Care has been taken to minimize the signal dependence of the power supply currents; however, the analog supply currents will be proportional to the reference input. With REFIN at 2.5 V , the typical current into $\mathrm{AV}_{\text {DD }}$ is 82 mA , while the typical current out of $\mathrm{AV}_{\mathrm{SS}}$ is 115 mA . Typically, 33 mA will flow into the AGND pin.
Careful design and the use of differential circuitry provide the AD871 with excellent rejection of power supply noise over a wide range of frequencies, as illustrated in Figure 29.


Figure 29. Power Supply Rejection vs. Frequency, 100 mV p-p Signal on Power Supplies
Figure 30 shows the degradation in SNR resulting from 100 mV of power supply ripple at various frequencies. As Figure 30 shows, careful decoupling is required to realize the specified dynamic performance. Figure 34 demonstrates the recommended decoupling strategy for the supply pins. Note that in extremely noisy environments, a more elaborate supply filtering scheme may be necessary.


Figure 30. SNR vs. Supply Noise Frequency $\left(f_{I N}=1 \mathrm{MHz}\right)$

## DIGITAL SUPPLIES AND GROUNDS

The digital activity on the AD871 chip falls into two general categories: CMOS correction logic, and CMOS output drivers. The internal correction logic draws relatively small surges of current, mainly during the clock transitions; in the 44 -pin package, these currents flow through pins DGND and DV $_{\text {DD }}$. The
output drivers draw large current impulses while the output bits are changing. The size and duration of these currents is a function of the load on the output bits: large capacitive loads are to be avoided. In the 44-pin package, the output drivers are supplied through dedicated pins DRGND and DRV ${ }_{\text {DD }}$. Pin count constraints in the 28 -pin packages require that the digital and driver supplies share package pins (although they have separate bond wires and on-chip routing). The decoupling shown in Figure 34 is appropriate for a reasonable capacitive load on the digital outputs (typically 20 pF on each pin). Applications involving greater digital loads should consider increasing the digital decoupling proportionately, and/or using external buffers/latches.

## APPLICATIONS

## OPTIONAL ZERO AND GAIN TRIM

The AD871 is factory trimmed to minimize zero error, gain error and linearity errors. In some applications the zero and gain errors of the AD871 need to be externally adjusted to zero. If required, both zero error and gain error can be trimmed with external potentiometers as shown in Figure 31. Note that gain error adjustments must be made with an external reference.
Zero trim should be adjusted first. Connect $V_{\text {INA }}$ to ground and adjust the $10 \mathrm{k} \Omega$ potentiometer such that a nominal digital output code of 000000000000 (twos complement output) exists. Note that the zero trim should be decoupled and that the accuracy of the $\pm 2.5 \mathrm{~V}$ reference signals will directly affect the offset.
Gain error may then be calibrated by adjusting the REF IN voltage. The REF IN voltage should be adjusted such that a +1 V input on $\mathrm{V}_{\text {INA }}$ results in the digital output code 01111 11111111 (twos complement output).


Figure 31. Zero and Gain Error Trims

## DIGITAL OFFSET CORRECTION

The AD871 provides differential inputs that may be used to correct for any offset voltages on the analog input. For applications where the input signal contains a dc offset, it may be advantageous to apply a nulling voltage to the $\mathrm{V}_{\mathrm{INB}}$ input. Applying a voltage equal to the dc offset will maximize the full-scale input range and therefore the dynamic range. Offsets ranging from -0.7 V to +0.5 V can be corrected.
Figure 32 shows how a dc offset can be applied using the AD568 12-bit, high speed digital-to-analog converter (DAC). This circuit can be used for applications requiring offset adjustments on every clock cycle. The AD568 connection scheme is used to provide a -0.512 V to +0.512 V output range. The offset voltage must be stable on the rising edge of the AD871 clock input.


Figure 32. Offset Correction Using the AD568
UNDERSAMPLING USING THE AD871 AND AD9100
The AD871's on-chip THA optimizes transient response while maintaining low noise performance. For super-Nyquist (undersampling) applications it may be necessary to use an external THA with fast track-mode slew rate and hold mode settling time. An excellent choice for this application is the AD9100, an ultrahigh speed track-and-hold amplifier.
In order to maximize the spurious free dynamic range of the circuit in Figure 33 it is advantageous to present a small signal to the input of the AD9100 and then amplify the output to the AD871's full-scale input range. This can be accomplished with a low distortion, wide bandwidth amplifier such as the AD9617. The circuit uses a gain of 3.5 to optimize $\mathrm{S} /(\mathrm{N}+\mathrm{D})$.

The peak performance of this circuit is obtained by driving the AD871 + AD9100 combination with a full-scale input. For small scale input signals ( $-20 \mathrm{~dB},-40 \mathrm{~dB}$ ), the AD871 performs better without the track-and-hold because slew-limiting effects are no longer dominant. To gain the advantages of the added track-and-hold, it is important to give the AD871 a full-scale input.
An alternative to the configuration presented above is to use the AD9101 track-and-hold amplifier. The AD9101 provides a builtin post amplifier with a gain of 4 , providing excellent ac characteristics in conjunction with a high level of integration.
As illustrated in Figure 33, it is necessary to skew the AD871 sample clock and the AD9100 sample/hold control. Clock skew ( $\mathrm{t}_{\mathrm{s}}$ ) is defined as the time starting at the AD9100's transition into hold mode and ending at the moment the AD871 samples. The AD871 samples on the rising edge of the sample clock, and the AD9100 samples on the falling edge of the sample/hold control. The choice of $t_{\mathrm{S}}$ is primarily determined by the settling time of the AD9100. The droop rate of the AD9100 must also be taken into consideration. Using these values, the ideal $t_{s}$ is 17 ns . When choosing clock sources, it is extremely important that the front end track-and-hold sample/hold control is given a very low jitter clock source. This is not as crucial for the AD871 sample clock, because it is sampling a dc signal.


Figure 33. Undersampling Using the AD871 and AD9100


Figure 34. AD872/AD871 Evaluation Board Schematic Complete 12-Bit 10 MSPS Monolithic A/D Converter

## FEATURES

Monolithic 12-Bit 10 MSPS A/D Converter<br>Low Power Dissipation: 1.15 W<br>No Missing Codes Guaranteed Differential Nonlinearity Error: 0.5 LSB<br>Complete: On-Chip Track-and-Hold Amplifier and Voltage Reference<br>Signal-to-Noise and Distortion Ratio: 65 dB<br>Spurious-Free Dynamic Range: 72 dB<br>Out of Range Indicator<br>Twos Complement Binary Output Data<br>$\mathbf{2 8 - P i n}$ Ceramic DIP or 44-Pin Surface Mount Package

## PRODUCT DESCRIPTION

The AD872 is a monolithic 12 -bit, 10 Msps analog to digital converter with an on-chip, high performance track-and-hold amplifier and voltage reference. The AD872 uses a multistage differential pipelined architecture with output error correction logic to provide 12 -bit accuracy at 10 Msps data rates and guarantees no missing codes over the full operating temperature range. The AD872 combines a merged high speed bipolar/ CMOS process and a novel architecture to achieve the resolution and speed of hybrid implementations at a fraction of the power consumption. Additionally, the greater reliability of monolithic construction offers improved system reliability and lower costs than hybrid designs.
The high input impedance, fast-settling input track-and-hold (T/H) amplifier is equally suited for both multiplexed systems that switch negative to positive full-scale voltage levels in successive channels and sampling single-channel inputs at frequencies up to and beyond the Nyquist rate. The AD872's wideband input combined with the power and cost savings over previously available hybrids will allow new design opportunities in communications, imaging and medical applications. The AD872 provides both reference output and reference input pins, allowing the onboard reference to serve as a system reference. An external reference can also be chosen to suit the dc accuracy and temperature drift requirements of the application. A single clock input is used to control all internal conversion cycles. The digital output data is presented in twos complement binary output format. An out-of-range signal indicates an overflow condition. It can be used with the most significant bit to determine low or high overflow.

FUNCTIONAL BLOCK DIAGRAM


The AD872 is fabricated on Analog Devices ABCMOS-1 process which utilizes high speed bipolar and CMOS transistors on a single chip. High speed, precision analog circuits are now combined with high density logic circuits.
The AD872 is packaged in a 28 -pin ceramic DIP and a 44 -pin leadless ceramic surface mount package and is specified for operation from $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ and $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.

## PRODUCT HIGHLIGHTS

The AD872 offers a complete single-chip sampling 12-bit, 10 Msps analog-to-digital conversion function in a 28 -pin DIP or 44-pin leadless ceramic surface mount package (LCC).
Low Power-The AD872 at 1.15 W consumes a fraction of the power of presently available hybrids.
Onboard Track-and-Hold (T/H)-The high impedance T/H input eliminates the need for external buffers and can be configured for single ended or differential inputs.
Out of Range (OTR)-The OTR output bit indicates when the input signal is beyond the AD872's input range.
Ease-of-Use-The AD872 is complete with T/H and voltage reference.

[^18]
## AD872 - SPECIFICATIONS

 indicated)

| Parameter | J Grade ${ }^{1}$ | S Grade ${ }^{1}$ | Units |
| :---: | :---: | :---: | :---: |
| RESOLUTION | 12 | 12 | Bits min |
| MAX CONVERSION RATE | 10 | 10 | MHz min |
| ACCURACY <br> Integral Nonlinearity (INL) <br> Differential Nonlinearity (DNL) <br> No Missing Codes <br> Zero Error $\left(\left(\text { ( } 1+25^{\circ} \mathrm{C}\right)^{2}\right.$ <br> Gain Error $\left(\left(11+25^{\circ} \mathrm{C}\right)^{2}\right.$ | $\begin{aligned} & \pm 2.5 \\ & \pm 0.5 \\ & 12 \\ & \pm 0.75 \\ & \pm 1.25 \end{aligned}$ | $\begin{aligned} & \pm 2.5 \\ & \pm 0.5 \\ & 12 \\ & \pm 0.75 \\ & \pm 1.25 \end{aligned}$ | LSB typ <br> LSB typ <br> Bits Guaranteed <br> \% FSR max <br> \% FSR max |
| ```TEMPERATURE DRIFT }\mp@subsup{}{}{3 Zero Error Gain Error }\mp@subsup{}{}{3.4 Gain Error }\mp@subsup{}{}{3.5``` | $\begin{aligned} & \pm 0.15 \\ & \pm 0.80 \\ & \pm 0.25 \end{aligned}$ | $\begin{aligned} & \pm 0.30 \\ & \pm 1.75 \\ & \pm 0.50 \end{aligned}$ | \% FSR max <br> \% FSR max <br> \% FSR max |
| POWER SUPPLY REJECTION ${ }^{6}$ $\begin{aligned} & \mathrm{AV}_{\mathrm{DD}}, \mathrm{DV}_{\mathrm{DD}}(+5 \mathrm{~V} \pm 0.25 \mathrm{~V}) \\ & \mathrm{AV}_{\mathrm{ss}}(-5 \mathrm{~V} \pm 0.25 \mathrm{~V}) \end{aligned}$ | $\begin{aligned} & \pm 0.125 \\ & \pm 0.125 \end{aligned}$ | $\begin{aligned} & \pm 0.125 \\ & \pm 0.125 \end{aligned}$ | \% FSR max <br> \% FSR max |
| ANALOG INPUT <br> Input Range Input Resistance Input Capacitance | $\begin{aligned} & \pm 1 \\ & 50 \\ & 10 \end{aligned}$ | $\begin{aligned} & \pm 1 \\ & 50 \\ & 10 \end{aligned}$ | Volts max $\mathrm{k} \Omega$ typ pF typ |
| INTERNAL VOLTAGE REFERENCE <br> Output Voltage <br> Output Voltage Tolerance <br> Output Current (Available for External Loads) <br> (External load should not change during conversion.) | $\begin{aligned} & 2.5 \\ & \pm 20 \\ & 2.0 \end{aligned}$ | $\begin{aligned} & 2.5 \\ & \pm 40 \\ & 2.0 \end{aligned}$ | Volts typ mV max mA typ |
| REFERENCE INPUT RESISTANCE | 5 | 5 | k $\Omega$ typ |
| $\begin{aligned} & \text { POWER SUPPLIES } \\ & \text { Supply Voltages } \\ & \mathrm{AV}_{\mathrm{DD}} \\ & \mathrm{AV}_{\mathrm{SS}} \\ & \mathrm{DV}_{\mathrm{DD}} \\ & \text { Supply Current }^{\mathrm{IAV}_{\mathrm{DD}}} \\ & \text { IAV }_{\mathrm{SS}} \\ & \mathrm{IDV}_{\mathrm{DD}} \end{aligned}$ | $\begin{aligned} & +5 \\ & -5 \\ & +5 \\ & \\ & 87 \\ & 147 \\ & 20 \end{aligned}$ | $\begin{aligned} & +5 \\ & -5 \\ & +5 \\ & \\ & 88 \\ & 150 \\ & 21 \end{aligned}$ | $\begin{aligned} & \mathrm{V}\left( \pm 5 \% \mathrm{AV}_{\mathrm{DD}} \text { Operating }\right) \\ & \mathrm{V}\left( \pm 5 \% \mathrm{AV}_{\text {ss }} \text { Operating }\right) \\ & \mathrm{V}( \pm 5 \% \mathrm{DV} \text { DD Operating }) \\ & \operatorname{mA} \max (78 \mathrm{~mA} \text { typ }) \\ & \mathrm{mA} \max (134 \mathrm{~mA} \text { typ }) \\ & \mathrm{mA} \max (15 \mathrm{~mA} \text { typ }) \end{aligned}$ |
| POWER CONSUMPTION | $\begin{aligned} & 1.15 \\ & 1.25 \\ & \hline \end{aligned}$ | $\begin{aligned} & 1.15 \\ & 1.3 \\ & \hline \end{aligned}$ | W typ <br> W max |

## NOTES

${ }^{1}$ Temperature ranges are as follows: J Grade: $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}, \mathrm{S}$ Grade: $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
${ }^{2}$ Adjustable to zero with external potentiometers (See Zero and Gain Error Calibration section).
${ }^{3}+25^{\circ} \mathrm{C}$ to $\mathrm{T}_{\text {MIN }}$ and $+25^{\circ} \mathrm{C}$ to $\mathrm{T}_{\text {MAX }}$.
${ }^{4}$ Includes internal voltage reference error.
${ }^{5}$ Excludes internal reference drift.
${ }^{6}$ Change in Gain Error as a function of the dc supply voltage.
Specifications subject to change without notice.


|  | J Grade | S Grade | Units |
| :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { SIGNAL-TO-NOISE AND DISTORTION RATIO }(\mathrm{S} / \mathrm{N}+\mathrm{D}) \\ & \mathrm{f}_{\text {INPUT }}=1 \mathrm{MHz} \\ & \mathrm{f}_{\text {INPUT }}=4.99 \mathrm{MHz} \end{aligned}$ | $\begin{aligned} & 65 \\ & 61 \\ & 63 \end{aligned}$ | $\begin{aligned} & 64 \\ & 61 \\ & 63 \end{aligned}$ | dB typ dB min dB typ |
| $\begin{aligned} & \text { TOTAL HARMONIC DISTORTION }(\mathrm{THD}) \\ & \mathrm{f}_{\text {INPUT }}=1 \mathrm{MHz} \\ & \mathrm{f}_{\text {INPUT }}=4.99 \mathrm{MHz} \end{aligned}$ | $\begin{aligned} & -70 \\ & -63 \\ & -66 \end{aligned}$ | $\begin{aligned} & -68 \\ & -62 \\ & -65 \end{aligned}$ | dB typ dB max dB typ |
| $\begin{aligned} & \text { SPURIOUS FREE DYNAMIC RANGE } \\ & \mathrm{f}_{\text {INPLT }}=1 \mathrm{MHz} \\ & \mathrm{f}_{\text {INPLT }}=4.99 \mathrm{MHz} \\ & \hline \end{aligned}$ | $\begin{aligned} & 72 \\ & 70 \end{aligned}$ | $\begin{aligned} & 72 \\ & 70 \end{aligned}$ | dB typ <br> dB typ |
| INTERMODULATION DISTORTION (IMD) ${ }^{2}$ | 70 | 70 | dB typ |
| FULL POWER BANDWIDTH | 70 | 70 | MHz typ |
| SMALL SIGNAL BANDWIDTH | 70 | 70 | MHz typ |
| APERTURE DELAY | 8 | 8 | ns typ |
| APERTURE JITTER | 10 | 10 | ps. rms typ |
| ACQUISITION TO FULL-SCALE STEP | 40 | 40 | ns typ |
| OVERVOLTAGE RECOVERY TIME | 40 | 40 | ns typ |

## NOTES

${ }^{1} \mathrm{f}_{\mathrm{iN}}$ amplitude $=-0.5 \mathrm{~dB}$ full scale unless otherwise indicated. All measurements referred to a $0 \mathrm{~dB}(1 \mathrm{~V} \mathrm{pk})$ input signal unless otherwise indicated. ${ }^{2} \mathrm{fa}=1.0 \mathrm{MHz}, \mathrm{fb}=0.95 \mathrm{MHz}$ with $\mathrm{f}_{\text {SAMPLE }}=10 \mathrm{MHz}$, typical value for second and third order products.
Specifications subject to change without notice.

## DIGITAL SPECIFICATIONS ( $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {max }}$ with $\mathrm{AV}_{\mathrm{DD}}=+5 \mathrm{~V}, \mathrm{DV}_{\mathrm{DD}}=+5 \mathrm{~V}, \mathrm{AV}_{\mathrm{SS}}=-5 \mathrm{~V}$ unless otherwise noted)

| Parameter | Symbol | J, S Grades | Units |
| :---: | :---: | :---: | :---: |
| LOGIC INPUTS <br> High Level Input Voltage Low Level Input Voltage High Level Input Current ( $\mathrm{V}_{\mathrm{IN}}=\mathrm{DV}_{\mathrm{DD}}$ ) Low Level Input Current ( $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}$ ) Input Capacitance | $\mathrm{V}_{\mathrm{IH}}$ <br> $V_{\text {IL }}$ <br> $\mathrm{I}_{\mathrm{IH}}$ <br> $\mathrm{I}_{\mathrm{IL}}$ <br> $\mathrm{C}_{\text {IN }}$ | $\begin{aligned} & +2.0 \\ & +0.8 \\ & \pm 10 \\ & \pm 10 \\ & 5 \end{aligned}$ | $V_{\text {min }}$ <br> V max $\mu \mathrm{A}$ max $\mu \mathrm{A}$ max pF typ |
| LOGIC OUTPUTS <br> High Level Output Voltage ( $\mathrm{I}_{\mathrm{OH}}=0.5 \mathrm{~mA}$ ) <br> Low Level Output Voitage ( $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ ) <br> Output Capacitance <br> Leakage (Three-State, LCC Only) | $\mathrm{V}_{\mathrm{OH}}$ <br> $\mathrm{V}_{\mathrm{OL}}$ <br> Cout <br> IZ | $\begin{aligned} & +2.4 \\ & +0.4 \\ & 5 \\ & \pm 10 \end{aligned}$ | V min <br> V max pF typ $\mu \mathrm{A}$ max |

[^19]SWITCHING SPECIFICATIONS $\begin{aligned} & \left(\mathrm{T}_{\text {MIN }} \text { to } \mathrm{T}_{\text {MAx }} \text { with } \mathrm{VV}_{\text {OL }}=+5 \mathrm{~V}, \mathrm{DV}_{\mathrm{DD}}=+5 \mathrm{~V}, \mathrm{AV}_{S S}=-5 \mathrm{~V} ; \mathrm{V}_{\mathrm{OH}}=2.4 \mathrm{~V}\right)\end{aligned}$

| Parameter | Symbol | J, S Grades | Units |
| :---: | :---: | :---: | :---: |
| Clock Period ${ }^{1}$ | $\mathrm{t}_{\mathrm{C}}$ | 100 | ns min |
| CLOCK Pulse Width High | $\mathrm{t}_{\mathrm{CH}}$ | 45 | ns min |
| CLOCK Pulse Width Low | $\mathrm{t}_{\mathrm{CL}}$ | 45 | ns min |
| Clock Duty Cycle ${ }^{2}$ |  | 40 | \% min (50\% typ) |
|  |  | 60 | \% max |
| Output Delay | ${ }_{\text {tod }}$ | 10 | $\mathrm{ns} \min$ (20 ns typ) |
| Pipeline Delay (Latency) |  | 3 | Clock Cycles max |
| Data Access Time (LCC Package Only) ${ }^{3}$ | $\mathrm{t}_{\text {DD }}$ | 50 | ns typ (100 pF Load) |
| Output Float Delay (LCC Package Only) ${ }^{3}$ | $\mathrm{t}_{\mathrm{HL}}$ | 50 | ns typ ( 10 pF Load) |

## NOTES

${ }^{1}$ Conversion rate is operational down to 10 kHz without degradation in specified performance.
${ }^{2}$ For clock periods of 200 ns or greater, see Clock Input Section.
${ }^{3}$ See Section on Three-State Outputs for timing diagrams and application information.
Specifications subject to change without notice.


Figure 1. Timing Diagram

## ABSOLUTE MAXIMUM RATINGS ${ }^{\mathbf{1}}$

| Parameter | With Respect to | Min | Max | Units |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{AV}_{\text {DD }}$ | AGND | -0.5 | +6.5 | Volts |
| $\mathrm{AV}_{\text {Ss }}$ | AGND | -6.5 | +0.5 | Volts |
| DV ${ }_{\text {DD }}, \mathrm{DRV}^{\text {DD }}{ }^{2}$ | DGND, DRGND | -0.5 | +6.5 | Volts |
| $\mathrm{DRV}_{\text {DD }}{ }^{2}$ | $\mathrm{DV}_{\text {DD }}$ | -6.5 | +6.5 | Volts |
| DRGND ${ }^{2}$ | DGND | -0.3 | +0.3 | Volts |
| AGND | DGND | -1.0 | +1.0 | Volts |
| $\mathrm{AV}_{\text {DD }}$ | DV ${ }_{\text {DD }}$ | -6.5 | +6.5 | Volts |
| Clock Input, OEN | DGND | -0.5 | DV ${ }_{\text {DD }}+0.5$ | Volts |
| Digital Outputs | DGND | -0.5 | $D V_{D D}+0.3$ | Volts |
| $\mathrm{V}_{\text {INA }}, \mathrm{V}_{\text {INB }}$ REF IN | AGND | -6.5 | $+6.5$ | Volts |
| REF IN | AGND | $\mathrm{AV}_{\text {ss }}$ | $\mathrm{AV}_{\text {DD }}$ | Volts |
| Junction Temperature |  |  | +150 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature |  | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |
| Lead Temperature (10 sec) |  |  | +300 | ${ }^{\circ} \mathrm{C}$ |

## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum ratings for extended periods may affect device reliability.
${ }^{2}$ LCC Package Only.

PIN DESCRIPTION

| Symbol | DIP <br> Pin No. | LCC <br> Pin No. | Type | Name and Function |
| :---: | :---: | :---: | :---: | :---: |
| AGND | 5, 24 | 9, 36 | P | Analog Ground. |
| $\mathrm{AV}_{\text {DD }}$ | 4 | 6, 38 | P | +5 V Analog Supply. |
| $\mathrm{AV}_{\text {ss }}$ | 3, 25 | 5, 40 | P | -5 V Analog Supply. |
| $\overline{\text { MSB }}$ | 19 | 29 | DO | Inverted Most Significant Bit. Provides twos complement output data format. |
| MSB | N/A | 27 | DO | Most Significant Bit. |
| BIT 2-BIT 11 | 18-9 | 26-17 | DO | Data Bits 2 through 11. |
| BIT 12 (LSB) | 8 | 16 | DO | Least Significant Bit. |
| CLK | 21 | 31 | DI | Clock Input. The AD872 will initiate a conversion on the rising edge of the clock input. See the Timing Diagram for details. |
| DV ${ }_{\text {DD }}$ | 7, 22 | 33 | P | +5 V Digital Supply. |
| DGND | 6, 23 | 10 | P | Digital Ground. |
| DRV ${ }_{\text {DD }}$ | N/A | 12, 32 | P | +5V Digital Supply for the output drivers. |
| DRGND | N/A | 11, 34 | P | Digital Ground for the output drivers. (See section on Power Supply Decoupling for details on $\mathrm{DRV}_{\text {DD }}$ and DRGND.) |
| OTR | 20 | 30 | DO | Out of Range is Active HIGH on the leading edge of code 0 or the trailing edge of code 4096. See Output Data Format Table III. |
| OEN | N/A | 13 | DI | Output Enable. See the Three State Output Timing Diagram for details. |
| REF GND | 27 | 42 | AI | Reference Ground. |
| REF IN | 28 | 43 | AI | Reference Input. +2.5 V input gives $\pm 1 \mathrm{~V}$ full-scale range. |
| REF OUT | 26 | 41 | AO | +2.5 V Reference Output. Tie to REF IN for normal operation. |
| $\mathrm{V}_{\text {INA }}$ | 1 | 1 | AI | (+) Analog Input Signal on the differential input amplifier. |
| $\mathrm{V}_{\text {INB }}$ | 2 | 2 | AI | $(-)$ Analog Input Signal on the differential input amplifier. |
| NC | N/A | $\begin{aligned} & 3,4,7,8,14,15 \\ & 28,35,37,39,44 \end{aligned}$ |  | No Connect. |

TYPE: $\mathrm{AI}=$ Analog Input; $\mathrm{AO}=$ Analog Output; $\mathrm{DI}=$ Digital Input; $\mathrm{DO}=$ Digital Output; $\mathrm{P}=$ Power; $\mathrm{N} / \mathrm{A}=$ Not Available on 28-pin DIP. Only available on 44 -pin surface mount package.

## PIN CONFIGURATIONS

| 28-1 | in Ceramic | DIP |  |
| :---: | :---: | :---: | :---: |
| $v_{\mathrm{INA}}=1$ | AD872 <br> TOP VIEW (Not to Scale) | 28 | refin |
| $v_{\text {INB }} 2$ |  | 27 | REF GND |
| $\mathrm{AV}^{\text {ss }} 3$ |  | 26 | Ref out |
| $\mathrm{AV}^{\text {DD }}$ |  | 25 | $\mathrm{AV}_{\text {ss }}$ |
| agnd 5 |  | 24 | AGND |
| DGND 6 |  | 23 | DGND |
| $\mathrm{DV}_{\mathrm{DD}}{ }^{7}$ |  | 22 | $\mathrm{DV}_{\mathrm{DD}}$ |
| BIT 12 (LSB) 8 |  | 21 | CLK |
| BIT $11 \quad 9$ |  | 20 | OTR |
| BIT $10 \times 10$ |  | 19 | $\overline{\text { MSB }}$ |
| BIt 911 |  | 18 | BIT 2 |
| BIT 812 |  | 17 | віт 3 |
| BIT 713 |  | 16 | BIT 4 |
| BIT 614 |  | 15 | BIT 5 |

## DEFINITIONS OF SPECIFICATIONS

## LINEARITY ERROR

Linearity error refers to the deviation of each individual code from a line drawn from "negative full scale" through "positive full scale." The point used as "negative full scale" occurs $1 / 2$ LSB before the first code transition. "Positive full scale" is defined as a level $11 / 2$ LSB beyond the last code transition. The deviation is measured from the middle of each particular code to the true straight line.

## DIFFERENTIAL LINEARITY ERROR (DNL, NO MISSING CODES)

An ideal ADC exhibits code transitions that are exactly 1 LSB apart. DNL is the deviation from this ideal value. Guaranteed no missing codes to 12 -bit resolution indicates that all 4096 codes must be present over all operating ranges.

## ZERO ERROR

The major carry transition should occur for an analog value $1 / 2$ LSB below analog common. Zero error is defined as the deviation of the actual transition from that point. The zero error and temperature drift specify the initial deviation and maximum change in the zero error over temperature.

## GAIN ERROR

The first code transition should occur for an analog value $1 / 2$ LSB above nominal negative full scale. The last transition should occur for an analog value $11 / 2$ LSB below the nominal positive full scale. Gain error is the deviation of the actual difference between first and last code transitions and the ideal difference between first and last code transitions.

## TEMPERATURE DRIFT

The temperature drift for zero error and gain error specifies the maximum change from the initial $\left(25^{\circ} \mathrm{C}\right)$ value to the value at $\mathrm{T}_{\text {MIN }}$ or $\mathrm{T}_{\text {MAX }}$.

## POWER SUPPLY REJECTION

The specifications show the maximum change in the converter's full scale as the supplies are varied from nominal to $\mathrm{min} / \mathrm{max}$ values.

## APERTURE JITTER

Aperture jitter is the variation in aperture delay for successive samples and is manifested as noise on the input to the $A / D$.

## APERTURE DELAY

Aperture delay is a measure of the Track-and-Hold Amplifier (THA) performance and is measured from the rising edge of the clock input to when the input signal is held for conversion.

## OVERVOLTAGE RECOVERY TIME

Overvoltage recovery time is defined as that amount of time required for the ADC to achieve a specified accuracy after an overvoltage ( $50 \%$ greater than full-scale range), measured from the time the overvoltage signal reenters the converter's range.

## DYNAMIC SPECIFICATIONS

SIGNAL-TO-NOISE AND DISTORTION (S/N+D) RATIO $\mathrm{S} / \mathrm{N}+\mathrm{D}$ is the ratio of the rms value of the measured input signal to the rms sum of all other spectral components below the Nyquist frequency, including harmonics but excluding dc. The value for $\mathrm{S} / \mathrm{N}+\mathrm{D}$ is expressed in decibels.

## TOTAL HARMONIC DISTORTION (THD)

THD is the ratio of the rms sum of the first six harmonic components to the rms value of the measured input signal and is expressed as a percentage or in decibels.

## INTERMODULATION DISTORTION (IMD)

With inputs consisting of sine waves at two frequencies, fa and fb , any device with nonlinearities will create distortion products, of order ( $\mathrm{m}+\mathrm{n}$ ), at sum and difference frequencies of $\mathrm{mfa} \pm \mathrm{nfb}$, where $\mathrm{m}, \mathrm{n}=0,1,2,3 \ldots$ Intermodulation terms are those for which $m$ or $n$ is not equal to zero. For example, the second order terms are ( $\mathrm{fa}+\mathrm{fb}$ ) and ( $\mathrm{fa}-\mathrm{fb}$ ), and the third order terms are $(2 \mathrm{fa}+\mathrm{fb}),(2 \mathrm{fa}-\mathrm{fb}),(\mathrm{fa}+2 \mathrm{fb})$ and ( $2 \mathrm{fb}-\mathrm{fa}$ ). The IMD products are expressed as the decibel ratio of the rms sum of the measured input signals to the rms sum of the distortion terms. The two signals are of equal amplitude and the peak value of their sums is -0.5 dB from full scale. The IMD products are normalized to a 0 dB input signal.

## FULL-POWER BANDWIDTH

The full-power bandwidth is that input frequency at which the amplitude of the reconstructed fundamental is reduced by 3 dB for a full-scale input.

## SPURIOUS FREE DYNAMIC RANGE

The difference, in dB , between the rms amplitude of the input signal and the peak spurious signal.

## ORDERING GUIDE

| Model | Temperature Range | Package Option ${ }^{1}$ |
| :--- | :--- | :--- |
| AD872JD | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | D-28 |
| AD872JE | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | E-44A |
| AD872SD $^{2}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | D-28 |
| AD872SE $^{2}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | E-44A |

NOTES
${ }^{1} \mathrm{D}=$ Ceramic DIP, E $=$ Leadless Ceramic Chip Carrier. For outline information see Package Information section.
${ }^{2}$ MIL-STD-883 and SMD versions available; contact factory.


Figure 2. AD872 $S /(N+D)$ vs. Input Frequency


Figure 3. AD872 Distortion vs. Input Frequency, Full-Scale Input


Figure 4. AD872 Typical FFT, $f_{I N}=1 \mathrm{MHz}$


Figure 5. AD872 Typical FFT, $f_{I N}=5 \mathrm{MHz}$

## AD872-Dynamic Characteristics-Sample Rate: 5 MSPS



Figure 6. AD872 $S /(N+D)$ vs. Input Frequency


Figure 7. AD872 Distortion vs. Input Frequency, Full-Scale Input


Figure 8. AD872 Typical FFT, $f_{I N}=1 \mathrm{MHz}$


Figure 9. AD872 Typical FFT, $f_{I N}=2 M H z$

## THEORY OF OPERATION

The AD872 is implemented using a 4 -stage pipelined multiple flash architecture. A differential input track-and-hold amplifier (THA) acquires the input and converts the input voltage into a differential current. A 3-bit approximation of the input is made by the first flash converter, and an accurate analog representation of this 3-bit guess is generated by a digital-to-analog converter. This approximation is subtracted from the THA output to produce a remainder, or residue. This residue is then sampled and held by the second THA, and a 4-bit approximation is generated and subtracted by the second stage. Once the second THA goes into hold, the first stage goes back into track to acquire a new input signal. The third stage provides another 4-bit approximation/subtraction operation, and produces the final residue, which is passed to a final 4 -bit flash converter. The 15 output bits from the 4 flash converters are accumulated in the correction logic block, which adds the bits together using the appropriate correction algorithm, to produce the 12 -bit output word. The digital output, together with overrange indicator, is latched into an output buffer to drive the output pins.
The additional THA inserted in each stage of the AD872 architecture allows pipelining of the conversion. In essence, the converter is converting multiple inputs simultaneously, processing them through the converter chain serially. This means that while the converter is capable of capturing a new input sample every clock cycle, it actually takes three clock cycles for the conversion to be fully processed and appear at the output. This "pipeline delay" is often referred to as latency, and is not a concern in most applications, however there are some cases where it may be a consideration. For example, some applications call for the A/D converter to be placed in a high speed feedback loop, where its input is servoed to provide a desired result at the digital output (e.g., offset calibration or zero restoration in video applications). In these cases the 3 clock cycle delay through the pipeline must be accounted for in the loop stability calculations. Also, because the converter is working on three conversions simultaneously, major disruptions to the part (such as a large glitch on the supplies or reference) may corrupt three data samples. Finally, there will be a minimum clock rate below which the THA droop corrupts the signal in the pipeline. In the case of the AD872, this minimum clock rate is 10 kHz .

The high impedance differential inputs of the AD872 allow a variety of input configurations (see APPLYING THE AD872). The AD872 converts the voltage difference between the $\mathrm{V}_{\text {INA }}$ and $V_{\text {INB }}$ pins. For single-ended applications, one input pin ( $\mathrm{V}_{\text {INA }}$ or $\mathrm{V}_{\text {INB }}$ ) may be grounded, but even in this case the differential input can provide a performance boost: for example, for an input coming from a coaxial cable, $\mathrm{V}_{\mathrm{INB}}$ can be tied to the shield ground, allowing the AD872 to reject shield noise as common mode. The high input impedance of the device minimizes external driving requirements and allows the user to externally select the appropriate termination impedance for the application.
The AD872 clock circuitry uses both edges of the clock in its internal timing circuitry (see spec page for exact timing requirements.) The AD872 samples the analog input on the rising edge of the clock input. During the clock low time (between the falling edge and rising edge of the clock) the input THA is in track mode; during the clock high time it is in hold. System disturbances just prior to the rising edge of the clock may cause the part to acquire the wrong value, and should be minimized.

While the part uses both clock edges for its timing, jitter is only a significant issue for the rising edge of the clock (see CLOCK INPUT section).

## APPLYING THE AD872

## ANALOG INPUTS

The AD872 features a high impedance differential input that can readily operate on either single-ended or differential input signals. Table I summarizes the nominal input voltage span for both single-ended and differential modes, assuming a 2.5 V reference input.

Table I. Input Voltage Span

|  | $\mathbf{V}_{\text {INA }}$ | $\mathbf{V}_{\text {INB }}$ | $\mathbf{V}_{\text {INA }}-\mathbf{V}_{\text {INB }}$ |
| :--- | :--- | :--- | :--- |
| Single-Ended | +1 V | GND | +1 V (Positive Full Scale) |
|  | -1 V | GND | -1 V (Negative Full Scale) |
| Differential | +0.5 V | -0.5 V | +1 V (Positive Full Scale) |
|  | -0.5 V | +0.5 V | -1 V (Negative Full Scale) |

Figure 10 shows an approximate model for the analog input circuit. As this model indicates, when the input exceeds 1.6 V (with respect to AGND), the input device may saturate, causing the input impedance to drop substantially and significantly reducing the performance of the part. Input compliance in the negative direction is somewhat larger, showing virtually no degradation in performance for inputs as low as -1.9 V .


Figure 10. AD872 Equivalent Analog Input Circuit
Figure 11 illustrates the effect of varying the common-mode voltage of a -1 dB input signal on total harmonic distortion.


Figure 11. AD872 Total Harmonic Distortion vs. CM Input Voltage, $f_{I N}=1 \mathrm{MHz}, F S=10 \mathrm{MSPS}$

Figure 12 shows the common-mode rejection performance vs. frequency for a 1 V p-p common mode input. This excellent common-mode rejection out over a wide bandwidth affords the user the opportunity to eliminate many potential sources of input noise as common mode by using the differential input structure of the AD872.


Figure 12. Common-Mode Rejection vs. Input Frequency, 1 V p-p Input
Figures 13 and 14 illustrate typical input connections for singleended inputs.


Figure 13. AD872 Single-Ended Input Connection


Figure 14. AD872 Single-Ended Input Connection Using a Shielded Cable

The cable shield is used as the ground connection for the $\mathrm{V}_{\text {INB }}$ input, providing the best possible rejection of the cable noise from the input signal. Note also that the high input impedance of the AD872 allows the user to select his own termination impedance, be it 50 ohms, 75 ohms, or some other value. Furthermore, unlike many flash converters, most AD872 applica-
tions will not require an external buffer amplifier. If such an amplifier is required, we suggest either the AD811 or AD9617.

Figure 15 illustrates how external amplifiers may be used to convert a single-ended input into a differential signal. The resistor values of $536 \Omega$ and $562 \Omega$ were selected to provide optimum phase matching between U 1 and U 2 .


Figure 15. Single-Ended to Differential Connections; U1, U2 = AD811 or AD9617

The use of the differential input signal can help to minimize even-order distortion from the input THA where performance beyond -70 dB is desired.
Figure 16 shows the AD872 large signal ( -0.5 dB ) and small signal ( -20 dB ) frequency response.


Figure 16. Full Power ( -0.5 dB ) and Small Signal Response (-20 dB) vs. Input Frequency

The AD872's wide input bandwidth facilitates rapid acquisition of transient input signals: the input THA can typically settle to 12-bit accuracy from a full-scale input step in less than 40 ns . Figure 17 illustrates the typical acquisition of a full-scale input step.


Figure 17. Typical AD872 Settling Time
The wide input bandwidth and superior dynamic performance of the input THA makes the AD872 suitable for undersampling applications where the input frequency exceeds half the sampling frequency. The input THA is designed to recover rapidly from input overdrive conditions, returning from a $50 \%$ overdrive in less than 50 ns.
Because of the THA's exceptionally wide input bandwidth, some users may find the AD872 is sensitive to noise at frequencies from 50 MHz to 100 MHz that other converters are incapable of responding to. This sensitivity can be mitigated by careful use of the differential inputs (see previous paragraphs). Additionally, Figure 18 shows how a small capacitor ( $10 \mathrm{pF}-20 \mathrm{pF}$ for 50 -ohm terminated inputs) may be placed between $\mathrm{V}_{\mathrm{INA}}$ and $\mathrm{V}_{\text {INB }}$ to help reduce high frequency noise in applications where limiting the input bandwidth is acceptable.


Figure 18. Optional High Frequency Noise Reduction
The AD872 will contribute its own wideband thermal noise. As a result of the integrated wideband noise ( $1 / 2$ LSB rms, referred-to-input), applying a dc analog input produces more than one code at the output. A histogram analysis of the AD872 with a dc input will show a bell shaped curve consistent with the Guassian nature of the thermal noise. This histogram will be between 3 and 5 codes wide, depending on how well the input is centered on a given code and how many samples are taken.

## REFERENCE INPUT

The nominal reference input should be 2.5 V , taken with respect to REFERENCE GROUND (REF GND). Figure 19 illustrates the equivalent model for the reference input: there is no clock or signal-dependent activity associated with the reference input circuitry, therefore, no "kickback" into the reference.


Figure 19. Equivalent Reference Input Circuit
The AD872's input impedance is $5 \mathrm{k} \Omega$, with a tolerance of $\pm 20 \%$. The effective noise bandwidth through the input channel is 10 MHz , and the referred-to-input noise gain is 0.4 . For example, the internal reference, with peak-to-peak noise of $180 \mu \mathrm{~V}$ (using an external $1 \mu \mathrm{~F}$ capacitor), contributes 0.3 LSBs of noise to the transfer function of the AD872.
The full-scale peak-to-peak input voltage is a function of the reference voltage, according to the equation:

$$
\left(V_{I N A}-V_{I N B}\right) \text { Full Scale }=0.8^{\star}\left(V_{R E F}-R E F G N D\right)
$$

Note that the AD872's performance was optimized for a 2.5 V reference input: performance will degrade somewhat for other reference voltages. Figure 20 illustrates the $\mathrm{S} /(\mathrm{N}+\mathrm{D})$ performance vs. reference voltage for a $1 \mathrm{MHz},-0.5 \mathrm{~dB}$ input signal. Note also that if the reference is changed during a conversion, all three conversions in the pipeline will be invalidated.


Figure 20. $S /(N+D)$ vs. Reference Input Voltage, $f_{I N}=1 \mathrm{MHz}, F S=10 \mathrm{MHz}$

Table II summarizes various 2.5 V references suitable for use with the AD872, including the onboard bandgap reference (see REFERENCE OUTPUT section).

Table II. Suitable 2.5 V References

|  | Drift <br> $(\mathbf{P P M} / \circ \mathbf{C})$ | Initial Accuracy <br> $\%$ |
| :--- | :--- | :--- |
| REF-43B | $6(\max )$ | 0.2 |
| AD680JN | $10(\max )$ | 0.4 |
| Internal | 30 (typ) | 0.4 |

If an external reference is connected to REF IN, REF OUT must be connected to +5 V . This should lower the current in REF GND to less than $350 \mu \mathrm{~A}$, and eliminate the need for a $1 \mu \mathrm{~F}$ capacitor.
Alternatively, Figure 21 shows how the AD872 may be driven from other references by use of an external resistor. The external resistor forms a resistor divider with the on-chip $5 \mathrm{k} \Omega$ resistor to realize 2.5 V at the reference input pin (REF IN). A trim potentiometer is recommended to accommodate the tolerance of the AD872's $5 \mathrm{k} \Omega$ resistor.


Figure 21. Optional +5 V Reference Input Circuit

## REFERENCE GROUND

The REF GND pin provides the reference point for both the reference input, and the reference output. When the internal reference is operating, it will draw approximately $500 \mu \mathrm{~A}$ of current through the reference ground, so a low impedance path to the external common is desirable. The AD872 can tolerate a fairly large difference between REF GND and AGND, up to $\pm 1 \mathrm{~V}$, without any performance degradation.

## REFERENCE OUTPUT

The AD872 features an onboard, curvature compensated bandgap reference that has been laser trimmed for both absolute value and temperature drift. The output stage of the reference was designed to allow the use of an external capacitor to limit the wideband noise. As Figure 22 illustrates, a $1 \mu F$ capacitor on the reference output is required for stability of the reference output buffer. Note: If used, an external reference may become unstable with this capacitor in place.


Figure 22. Typical Reference Decoupling Connection
With this capacitor in place, the noise on the reference output is approximately $30 \mu \mathrm{~V}$ rms at room temperature. Figure 23 shows the typical temperature drift performance of the reference, while Figure 24 illustrates the variation in reference voltage with load currents.


Figure 23. Reference Output Voltage vs. Temperature


Figure 24. Reference Output Voltage vs. Output Load
The output stage is designed to provide at least 2 mA of output current, allowing a single reference to drive up to four AD872s, or other external loads. The power supply rejection of the reference is better than 54 dB at dc.

## DIGITAL OUTPUTS

In 28-pin packages, the AD872 output data is presented in twos complement format. Table III indicates offset binary and twos complement output for various analog inputs.

Table III. Output Data Format

| Analog Input | Digital Output |  |  |
| :--- | :--- | :--- | :--- |
| $\mathbf{V}_{\text {INA }}-V_{\text {INB }}$ | Offset Binary | Twos Complement | OTR |
| $\geq 0.999756 \mathrm{~V}$ | 111111111111 | 011111111111 | 1 |
| 0.999268 V | 111111111111 | 011111111111 | 0 |
| 0 V | 100000000000 | 000000000000 | 0 |
| -1 V | 000000000000 | 100000000000 | 0 |
| -1.000244 V | 000000000000 | 100000000000 | 1 |

Users requiring offset binary encoding may simply invert the $\overline{\text { MSB }}$ pin. In the 44-pin surface mount packages, both MSB and $\overline{\text { MSB }}$ bits are provided.
The AD872 features a digital out-of-range (OTR) bit that goes high when the input exceeds positive full scale or falls below negative full scale. As Table III indicates, the output bits will be
set appropriately according to whether it is an out-of-range high condition or an out-of-range low condition.
The AD872's CMOS digital output drivers are sized to provide sufficient output current to drive a wide variety of logic families. However, large drive currents tend to cause glitches on the supplies and may affect $\mathrm{S} /(\mathrm{N}+\mathrm{D})$ performance. Applications requiring the AD872 to drive large capacitive loads or large fanout may require additional decoupling capacitors on $\mathrm{DRV}_{\text {DD }}$ and $\mathrm{DV}_{\mathrm{DD}}$. In extreme cases, external buffers or latches could be used.

## THREE-STATE OUTPUTS

The 44-pin surface mount AD872 offers three-state outputs. The digital outputs can be placed into a three-state mode by pulling the OUTPUT ENABLE (OEN) pin LOW. Note that this function is not intended to be used to pull the AD872 on and off a bus at 10 MHz . Rather, it is intended to allow the ADC to be pulled off the bus for evaluation or test modes. Also, to avoid corruption of the sampled analog signal during conversion ( 3 clock cycles), it is highly recommended that the AD872 be placed on the bus prior to the first sampling.


Figure 25. Three-State Output Timing Diagram
For timing budgetary purposes, the maximum access and float delay times for the AD872 are 200 ns .

## CLOCK INPUT

The AD872 internal timing control uses the two edges of the clock input to generate a variety of internal timing signals. The optimal clock input should have a $50 \%$ duty cycle; however, sensitivity to duty cycle is significantly reduced for clock rates of less than 10 megasamples per second.


Figure 26. Divide-by-Two Clock Circuit
Due to the nature of on-chip compensation circuitry, the duty cycle should be maintained between $40 \%$ and $60 \%$ even for clock rates less than 10 Msps . One way to realize a $50 \%$ duty cycle clock is to divide down a clock of higher frequency, as shown in Figure 26.

In this case, a 20 MHz clock is divided by 2 to produce the 10 MHz clock input for the AD872. In this configuration, the duty cycle of the 20 MHz clock is irrelevant.
The input circuitry for the CLKIN pin is designed to accommodate both TTL and CMOS inputs. The quality of the logic input, particularly the rising edge, is critical in realizing the best possible jitter performance for the part: the faster the rising edge, the better the jitter performance.
As a result, careful selection of the logic family for the clock driver, as well as the fanout and capacitive load on the clock line, is important. Jitter-induced errors become more predominant at higher frequency, large amplitude inputs, where the input slew rate is greatest.
The AD872 is designed to support a sampling rate of 10 Msps ; running at slightly faster clock rates may be possible, although at reduced performance levels. Conversely, some slight performance improvements might be realized by clocking the AD872 at slower clock rates. Figure 27 presents the SNR vs. clock frequency for a 1 MHz analog input.


Figure 27. Typical $S /(N+D)$ vs. Clock Frequency $f_{I N}=1 \mathrm{MHz}$, Full-Scale Input

The power dissipated by the correction logic and output buffers is largely proportional to the clock frequency; running at reduced clock rates provides a slight reduction in power consumption. Figure 28 illustrates this tradeoff.


Figure 28. Typical Power Dissipation vs. Clock Frequency

## ANALOG SUPPLIES AND GROUNDS

The AD872 features separate analog and digital supply and ground pins, helping to minimize digital corruption of sensitive analog signals. In general, $\mathrm{AV}_{\mathrm{SS}}$ and $\mathrm{AV}_{\mathrm{DD}}$, the analog supplies, should be decoupled to AGND, the analog common, as close to the chip as physically possible. Care has been taken to minimize the signal dependence of the power supply currents; however, the analog supply currents will be proportional to the reference input. With REFIN at 2.5 V , the typical current into $\mathrm{AV}_{\text {DD }}$ is 78 mA , while the typical current out of $\mathrm{AV}_{\text {SS }}$ is 134 mA . Typically, 55 mA will flow into the AGND pin.
Careful design and the use of differential circuitry provide the AD872 with excellent rejection of power supply noise over a wide range of frequencies, as illustrated in Figure 29.


Figure 29. Power Supply Rejection vs. Frequency, 100 mV p-p Signal on Power Supplies

Figure 30 shows the degradation in SNR ratio resulting from 100 mV of power supply ripple at various frequencies. As Figure 30 shows, careful decoupling is required to realize the specified dynamic performance. Figure 35 demonstrates the recommended decoupling strategy for the supply pins. Note that in extremely noisy environments, a more elaborate supply filtering scheme may be necessary.


Figure 30. SNR vs. Supply Noise Frequency $\left(f_{I N}=\right.$ 1 MHz )

## DIGITAL SUPPLIES AND GROUNDS

The digital activity on the AD872 chip falls into two general categories: CMOS correction logic, and CMOS output drivers. The internal correction logic draws relatively small surges of current, mainly during the clock transitions; in the 44 -pin package, these currents flow through pins DGND and $\mathrm{DV}_{\mathrm{DD}}$. The output drivers draw large current impulses while the output bits are changing. The size and duration of these currents is a function of the load on the output bits: large capacitive loads are to be avoided. In the 44 -pin package, the output drivers are supplied through dedicated pins DRGND and DRV ${ }_{\text {DD }}$. Pin count constraints in the 28 -pin packages require that the digital and driver supplies share package pins (although they have separate bond wires and on-chip routing). The decoupling shown in Figure 35 is appropriate for a reasonable capacitive load on the digital outputs (typically 20 pF on each pin). Applications involving greater digital loads should consider increasing the digital decoupling proportionately.

## APPLICATIONS

## OPTIONAL ZERO AND GAIN TRIM

The AD872 is factory trimmed to minimize zero error, gain error and linearity errors. In some applications the zero and gain errors of the AD872 need to be externally adjusted to zero. If required, both zero error and gain error can be trimmed with external potentiometers as shown in Figure 31. Note that gain error adjustments must be made with an external reference.
Zero trim should be adjusted first. Connect $\mathrm{V}_{\text {INA }}$ to ground and adjust the $10 \mathrm{k} \Omega$ potentiometer such that a nominal digital output code of 000000000000 (twos complement output) exists. Note that the zero trim should be decoupled and that the accuracy of the $\pm 2.5 \mathrm{~V}$ reference signals will directly affect the offset.
Gain error may then be calibrated by adjusting the REF IN voltage. The REF IN voltage should be adjusted such that a +1 V input on $\mathrm{V}_{\text {INA }}$ results in the digital output code 01111 11111111 (twos complement output).

(a) ZERO TRIM

(b) GAIN TRIM

Figure 31. Zero and Gain Error Trims


Figure 32. AD872 Evaluation Board Schematic

## FEATURES

Monolithic 10-Bit 30 MSPS A/D Converter
Power Dissipation: 530 mW
On-Chip Sample-and-Hold Amplifier
+5 V Single-Supply Operation
Signal-to-Noise Ratio $\mathrm{f}_{\mathrm{IN}}=\mathbf{3 . 5 8} \mathbf{~ M H z : ~} \mathbf{5 3} \mathbf{d B}$
Differential Nonlinearity: 0.8 LSB
Adjustable Reference Input
Differential Inputs
24-Pin "Skinny" DIP and 28-Pin SOIC

FUNCTIONAL BLOCK DIAGRAM


## PRODUCT HIGHLIGHTS

Sampling ADC: The differential input SHA eliminates the need for external buffering or sample-and-hold amplifiers.
Low Power: The AD873 has a typical power consumption of 500 mW . Reference ladder current is also low: 5 mA (typical), minimizing the reference power consumption.
Differential Nonlinearity: The AD873 features a typical DNL of 0.8 LSB. No missing codes guaranteed.
Single +5 V Supply Operation: The AD873 is designed to operate on a single +5 V supply.
Small Size: The AD873 is available in a space saving 24-pin "skinny" DIP and 28-pin SOIC.

[^20]This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.



Specifications subject to change without notice. See Definition of Specifications for additional information.

[^21] Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

| Parameter | Min | Typ |
| :--- | :---: | :---: |
| DYNAMIC PERFORMANCE |  | Max |
| Signal-to-Noise and Distortion (S/N+D) Ratio |  |  |
| $\mathrm{f}_{\mathrm{IN}}=1.0 \mathrm{MHz}$ |  |  |
| $\mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}$ |  |  |
| Signal-to-Noise Ratio (S/N) | 46 | dB |
| $\mathrm{f}_{\mathrm{IN}}=1.0 \mathrm{MHz}$ |  | dB |
| $\mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}$ | 53 | dB |
| Total Harmonic Distortion (THD) | 51 | dB |
| $\mathrm{f}_{\mathrm{IN}}=1.0 \mathrm{MHz}$ |  |  |
| $\mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}$ | -56 | dB |
| Spurious Free Dynamic Range ${ }^{1}$ | -47 | dB |
| Full Power Bandwidth | -56 | -TBD |
| Intermodulation Distortion (IMD) ${ }^{2}$ | 200 | dB |
| Second Order Products |  | MHz |
| Third Order Products |  | TBD |
| Differential Phase |  | TBD |
| Differential Gain |  | 1.5 |

NOTES
${ }^{1} \mathrm{f}_{\mathrm{IN}}=1 \mathrm{MHz}$.
${ }^{2} \mathrm{fa}=\mathrm{TBD} \mathrm{MHz}, \mathrm{fb}=$ TBD MHz.
Specifications subject to change without notice.

## TIMING SPECIFICATIONS

|  | Symbol - | Min Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: |
| MAXIMUM CONVERSION RATE ${ }^{1}$ | - | -30 |  | Msps |
| Clock Period | $\mathrm{t}_{\mathrm{C}}$ | $33-$ |  | ns |
| Clock High | $\mathrm{t}_{\mathrm{CH}}$ | 16 |  | ns |
| Clock Low | $\mathrm{t}_{\mathrm{CL}}$ | 16 |  | ns |
| Output Delay ${ }^{2}$ | $\mathrm{t}_{\text {OD }}$ | 8 |  | ns |
| Aperture Delay |  | TBD |  | ns |
| Aperture Jitter |  | TBD |  | ps |
| Pipeline Delay (Latency) |  | 5 |  | Clock Cycles |
| Output Rise Time ${ }^{2}$ | $\mathrm{t}_{\mathrm{R}}$ |  | 5 | ns . $\quad$ ? |
| Output Fall Time ${ }^{2}$ | $\mathrm{t}_{\mathrm{F}}$ |  | 5 | ns |

[^22]

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

## PIN DESCRIPTION

| Symbol | Pin No. DIP | Pin No. SOIC | Type | Name and Function |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{AV}_{\text {SS }}$ | 6 | 6, 7 | P | Analog Ground. |
| $\mathrm{AV}_{\mathrm{DD}}$ | 7 | 8,9 | P | +5 V Analog Supply. |
| BIT 1 (MSB) | 12 | 14 | DO | Most Significant Bit. |
| BIT 2-BIT 9 | 13-16, 21-24 | 15-18, 25-28 | DO | Data Bit 2 through Data Bit 9. |
| BIT 10 (LSB) | 1 | 1 | DO | Least Significant Bit. |
| CLK | 11 | 13 | DI | Clock Input. |
| DV ${ }_{\text {ss }}$ | 20 | 23, 24 | P | Digital Ground. |
| DV ${ }_{\text {DD }}$ | 17 | 19, 20 | P | +5 V Digital Supply. |
| $\mathrm{DRV}_{\text {Ss }}$ | 19 | 22 | P | Digital Ground for the digital output drivers. |
| $\mathrm{DRV}_{\text {DD }}$ | 18 | 21 | P | +5 V Digital Supply for the digital output drivers. |
| REFT | 9 | 11 | AI | Reference Top Input. |
| REFB | 8 | 10 | AI | Reference Bottom Input. |
| $\mathrm{V}_{\text {INA }}$ | 5 | 5 | AI | (+) Analog Input Signal to the differential input SHA. |
| $\mathrm{V}_{\text {INB }}$ | 4 | 4 | AI | $(-)$ Analog Input Signal to the differential input SHA. |
| CML | 3 | 3 | AO | Bypass pin for an internal bias point. |
| NC | 2, 10 | 2, 12 |  | No Connection. Connect to $\mathrm{AV}_{\text {Ss }}$. |

TYPE: $\mathrm{AI}=$ Analog Input, $\mathrm{AO}=$ Analog Output, $\mathrm{DI}=$ Digital Input, $\mathrm{DO}=$ Digital Output, $\mathrm{P}=$ Power.

## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :---: |
| AD873JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 24-Pin Plastic DIP | $\mathrm{N}-24$ |
| AD873JR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 28-Pin SOIC | $\mathrm{R}-28$ |

*For outline information see Package Information section.

ABSOLUTE MAXIMUM RATINGS*

| Parameter | With Respect to | Min | Max | Units |
| :--- | :--- | :--- | :--- | :--- |
| $\mathrm{AV}_{\mathrm{DD}}, \mathrm{DV}_{\mathrm{DD}}$ | $\mathrm{AV}_{\mathrm{SS}}, \mathrm{DV}_{\text {SS }}, \mathrm{DRV}_{\mathrm{SS}}$ | -0.5 | +6.5 | Volts |
| $\mathrm{AV}_{\mathrm{SS}}$ | $\mathrm{DV}_{\mathrm{SS}}, \mathrm{DRV}_{\mathrm{SS}}$ | -1.0 | +1.0 | Volts |
| Analog Inputs | $\mathrm{AV}_{\mathrm{SS}}$ | -0.5 | +6.5 | Volts |
| CLK | $\mathrm{DV}_{\mathrm{SS}}$ | -0.5 | +6.5 | Volts |
| Junction Temperature |  | +150 | ${ }^{\circ} \mathrm{C}$ |  |
| Storage Temperature | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |  |
| Lead Temperature $(10 \mathrm{sec})$ |  | +300 | ${ }^{\circ} \mathrm{C}$ |  |

*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum ratings for extended periods may affect device reliability.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD873 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

FEATURES
CMOS 10-Bit 15 MHz A/D Converter Low Power Dissipation: 185 mW +5 V Single-Supply Operation Differential Nonlinearity: 0.4 LSB
Guaranteed No Missing Codes
Power-Down (Standby) Mode: < $\mathbf{5 0} \mathbf{~ m W}$
Three-State Outputs
Digital I/Os Compatible with +5 V or +3.3 V Logic
Adjustable Reference Input
Small Size: 48-Pin Thin Quad Flatpack (TQFP)

## PRODUCT DESCRIPTION

The AD875 is a CMOS, low power 10-bit, 15 MHz analog-todigital converter (ADC). The AD875 combines high speed 10 -bit resolution and performance with low power and singlesupply operation. By implementing a multistage pipelined architecture with output error correction logic, the AD875 offers accurate performance and guarantees no missing codes over the full operating temperature range. To minimize external voltage drops, the reference ladder top and bottom are provided with force and sense pins.
The AD875's digital I/Os can interface to either +5 V or +3.3 V logic. The AD875 can be placed into a standby mode of operation reducing the power below 50 mW . Digital output data can be placed in a high impedance state and is offered in a variety of formats, including straight binary and twos complement output. The AD875 also provides both underrange and overrange output bits, indicating when the analog input has exceeded the analog input range.
The AD875's speed, resolution and single-supply operation are ideally suited for a variety of applications in imaging, high speed data acquisition and communications. The AD875's low power and single supply operation are required for high speed portable applications. Its speed and resolution are ideally suited for charge coupled device (CCD) input systems such as color scanners, digital copiers, electronic still cameras and camcorders.
The AD875 is packaged in a space saving 48 -pin thin quad flatpack (TQFP) and is specified over the commercial $\left(0^{\circ} \mathrm{C}\right.$ to $+70^{\circ} \mathrm{C}$ ) temperature range.

## FUNCTIONAL BLOCK DIAGRAM



## PRODUCT HIGHLIGHTS

Low Power-The AD875 at 185 mW consumes a fraction of the power of presently available 10 -bit, video-speed converters. Power-down mode and single-supply operation further enhance its desirability in low power, battery operated applications such as electronic still cameras, camcorders and communication systems.
Superior Differential Nonlinearity Performance-The AD875's typical DNL performance is 0.4 LSB and a maximum of 0.8 LSBs for the 0 to 255 code range (ideal for imaging systems). No missing codes are guaranteed.
Very Small Package-The AD875 is available in a 48 -pin surface mount, thin quad flatpack. The TQFP package is ideal for very tight, low headroom designs. The AD875 is available in tape-and-reel.

Digital I/O Functionality-The AD875 offers several digital features which allow output data formatting, fixed output test pattern generation to facilitate in-circuit testing, three-state output control and over/underrange indicators.

[^23]
## SPECIFICATIONS

DC SPECIFICATIONS ${ }^{\left(\mathrm{T}_{\text {MIN }}\right.}$ to $\mathrm{T}_{\text {max }}$ with $\mathrm{AV}_{\mathrm{DD}}=+5.0 \mathrm{~V}, \mathrm{DV}_{\mathrm{DD}}=+5.0 \mathrm{~V}$, $\mathrm{DRV}_{\mathrm{DD}}=+3.3 \mathrm{~V}, \mathrm{~V}_{\text {REFF }}=+4.0 \mathrm{~V}$,
( SPECIFICAIIONS $\mathrm{V}_{\text {Refb }}=+2.0 \mathrm{~V}, \mathrm{f}_{\text {clock }}=15 \mathrm{MHz}$, unless otherwise noted)

| Parameter | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: |
| RESOLUTION | 10 |  |  | Bits |
| DC ACCURACY <br> Integral Nonlinearity (INL) <br> Differential Nonlinearity (DNL) <br> Codes 0 to 255 <br> Codes 256 to 1023 <br> No Missing Codes <br> Offset <br> Gain |  | $\pm 1.5$ $\pm 0.4$ $\pm 0.4$ GUARANTEED 0.1 0.2 | $\begin{aligned} & \pm 2.5 \\ & \pm 0.8 \\ & \pm 1 \end{aligned}$ | LSB <br> LSB <br> LSB <br> \%FSR <br> \%FSR |
| ANALOG INPUT Input Range Input Resistance Input Current Input Capacitance | 1.8 | $\begin{aligned} & 2 \\ & 100 \\ & 10 \\ & 5 \end{aligned}$ | 2.2 | $\begin{aligned} & \text { V p-p } \\ & \mathrm{k} \Omega \\ & \mu \mathrm{~A} \\ & \mathrm{pF} \end{aligned}$ |
| REFERENCE INPUT <br> Reference Top Voltage Reference Bottom Voltage Reference Input Resistance Reference Input Current Force-Sense Offset Top Bottom | $\begin{aligned} & 3.6 \\ & 1.6 \\ & 250 \end{aligned}$ | $\begin{aligned} & 4.0 \\ & 2.0 \\ & 400 \\ & 5 \\ & 25 \\ & 25 \end{aligned}$ | $\begin{aligned} & 4.1 \\ & 2.1 \\ & 8 \end{aligned}$ | V <br> V <br> $\Omega$ <br> mA <br> mV <br> mV |
| POWER SUPPLIES <br> Operating Voltages <br> $\mathrm{AV}_{\mathrm{DD}}$ <br> $\mathrm{DV}_{\mathrm{DD}}$ <br> $\mathrm{DRV}_{\text {DD }}$ <br> Operating Current <br> $I A V_{D D}$ <br> IDV $_{\text {DD }}$ <br> IDRV $_{\text {DD }}{ }^{1}$ | $\begin{aligned} & +4.5 \\ & +4.5 \\ & +3.0 \end{aligned}$ | $\begin{aligned} & 19 \\ & 17 \\ & 1 \end{aligned}$ | $\begin{aligned} & +5.25 \\ & +5.25 \\ & +5.25 \end{aligned}$ <br> 34 <br> 25 <br> 5 | Volts <br> Volts <br> Volts <br> mA <br> mA <br> mA |
| POWER CONSUMPTION |  | 185 | 235 | mW |
| TEMPERATURE RANGE Operating | 0 |  | +70 | ${ }^{\circ} \mathrm{C}$ |

NOTES
${ }^{1} \mathrm{C}_{\mathrm{L}}=20 \mathrm{pF}$
Specifications subject to change without notice. See Definition of Specifications for additional information.

DIGITAL SPECIFICATIONS $\begin{aligned} & \left(\mathrm{T}_{\text {MIN }} \text { to } \mathrm{T}_{\text {max }} \text { with } \mathrm{AV}_{\mathrm{DD}}=+5.0 \mathrm{~V}, \mathrm{DV}_{\mathrm{DD}}=+5.0 \mathrm{~V} \text {, } \mathrm{DRV}_{\mathrm{DD}}=+3.3 \mathrm{~V}, \mathrm{~V}_{\text {REFFF }}=44.0 \mathrm{~V} \text {, }, ~+2.0 \mathrm{~V}, \mathrm{f}_{\text {Clock }}=15 \mathrm{MHz}, \mathrm{C}_{\mathrm{L}}=20 \mathrm{pF} \text { unless otherwise noted) }\right.\end{aligned}$

| Parameter | Symbol | DRV ${ }_{\text {DD }}$ | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| LOGIC INPUT |  | \% |  |  |  |  |
| High Level Input Voltage | $\mathrm{V}_{\mathrm{IH}}$ | 3.0 | 2.4 |  |  | V |
|  |  | 4.75 | 3.8 |  |  | V |
|  |  | 5.25 | 4.2 |  |  | V |
| Low Level Input Voltage | $\mathrm{V}_{\text {IL }}$ | 3.0 |  |  | 0.6 | V |
|  | * | 4.75 |  |  | 0.95 | V |
|  |  | 5.25 |  |  | 1.05 | V |
| High Level Input Current | $\mathrm{I}_{\text {IH }}$ | 4.75 | -10 |  | +10 | $\mu \mathrm{A}$ |
| Low Level Input Current | $\mathrm{I}_{\mathrm{IL}}$ | 4.75 | -50 |  | $+50$ | $\mu \mathrm{A}$ |
| Low Level Input Current (CLK Only) | $\mathrm{I}_{\text {IL }}$ | 4.75 | -10 |  | +10 | $\mu \mathrm{A}$ |
| Input Capacitance | $\mathrm{C}_{\text {IN }}$ |  |  | 5 |  | pF |
| LOGIC OUTPUTS |  |  |  |  |  |  |
| High Level Output Voltage | $\mathrm{V}_{\mathrm{OH}}$ |  |  |  |  |  |
| $\left(\mathrm{I}_{\mathrm{OH}}=50 \mu \mathrm{~A}\right)$ |  | 3.0 | 2.4 |  |  | V |
|  |  | 4.75 | 3.8 |  |  | V |
| ( $\mathrm{I}_{\mathrm{OH}}=0.5 \mathrm{~mA}$ ) |  | 4.75 | 2.4 |  |  | V |
| Low Level Output Voltage | $\mathrm{V}_{\text {OL }}$ |  |  |  |  |  |
| $\left(\mathrm{I}_{\text {OL }}=50 \mu \mathrm{~A}\right)$ |  | 3.6 |  |  | 0.7 | V |
|  |  | 5.25 |  |  | 1.05 | V |
| ( $\mathrm{I}_{\mathrm{OL}}=0.6 \mathrm{~mA}$ ) |  | 5.25 |  |  | 0.4 | V |
| Output Capacitance | $\mathrm{C}_{\text {OUt }}$ |  |  | 5 |  | pF |
| Output Leakage Current | $\mathrm{I}_{\mathrm{OZ}}$ |  | -10 |  | +10 | $\mu \mathrm{A}$ |

Specifications subject to change without notice.
TIMING SPECIFICATIONS $\begin{aligned} & \left(\mathrm{T}_{\text {MIN }} \text { to } \mathrm{T}_{\text {max }} \text { with } \mathrm{AV}_{\text {DD }}=+5.0 \mathrm{~V}, \mathrm{DV}_{\text {DD }}=+5.0 \mathrm{~V}, \mathrm{DRV}_{D D}=+3.3 \mathrm{~V}, \mathrm{~V}_{\text {REFFF }}=+4.0 \mathrm{~V} \text {, }, ~\right.\end{aligned}$

|  | Symbol | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Maximum Conversion Rate ${ }^{1}$ |  | 15 |  |  | MHz |
| Clock Period | $\mathrm{t}_{\mathrm{C}}$ | 66 |  |  | ns |
| Clock High | $\mathrm{t}_{\mathrm{CH}}$ | 30 | 33 |  | ns |
| Clock Low | $\mathrm{t}_{\mathbf{C L}}$ | 30 | 33 |  | ns |
| Output Delay ${ }^{2}$ | ${ }_{\text {tod }}$ | 12 | 15 |  | ns |
| Pipeline Delay (Latency) |  |  |  | 3 | Clock Cycles |
| Sampling Delay $1^{3}$ | $\mathrm{t}_{\text {s } 1}$ |  | 2.5 |  | ns |
| Sampling Delay $2^{3}$ | $\mathrm{t}_{\text {S } 2}$ |  | 2.5 |  | ns |
| External Settling Requirement ${ }^{3}$ | $\mathrm{V}_{\text {SE }}$ |  |  | $\pm 16$ | mV |

## NOTES

${ }^{1}$ Conversion rate is operational down to 10 kHz without degradation in specified performance.
${ }^{2} \mathrm{C}_{\mathrm{L}}=20 \mathrm{pF}$.
${ }^{3}$ See the section entitled "Driving the Analog Input."
Specifications subject to change without notice.


Figure 1. AD875 Timing Diagram

PIN DESCRIPTION

| Symbol | Pin No. | Type | Name and Function |
| :---: | :---: | :---: | :---: |
| D0 (LSB) | 1 | DO | Least Significant Bit |
| D1-D4 | 2-5 | DO | Data Bits 1 Through 4 |
| D5-D8 | 8-11 | DO | Data Bits 5 Through 8 |
| D9 (MSB) | 12 | DO | Most Significant Bit |
| UNR | 46 | DO | Underrange Output |
| OVR | 47 | DO | Overrange Output |
| TESTMODE | 19 | DI | TESTMODE $=$ LOW  <br> 1010... Pattern On $\frac{\text { TESTMODE }=\text { HIGH }}{\text { or N/C }}$ <br> D0-D9 Normal Operating Mode |
| LINV | 20 | DI | Invert the Lower Order Output Bits |
| MINV | 21 | DI | Invert the Most Significant Bit  <br> MINV = LOW MINV $=$ HIGH or N/C <br> No Inversion Invert MSB (D9) |
| THREESTATE | 23 | DI | THREE-STATE $=$ LOW  <br> Normal Operating Mode THREE-STATE $=$ HIGH <br> or N/C  <br> High Impedance Outputs  |
| STBY | 24 | DI | $\begin{array}{ll} \text { STBY }=\text { LOW } & \text { STBY }=\text { HIGH or N/C } \\ \hline \text { Normal Operating Mode } & \text { Standby Mode } \end{array}$ |
| CLK | 22 | DI | Clock Input |
| CML | 38 | AO | Bypass Pin for an Internal Bias Point. A $10 \mu \mathrm{~F}$ capacitor in parallel with a $0.1 \mu \mathrm{~F}$ capacitor must be connected to CML. CML is not to be used to drive external circuitry. |
| REFTS | 29 | AI | Reference Top Sense |
| REFTF | 30 | AI | Reference Top Force |
| REFTQ | 31 | AI | Reference Top Quarter Point (Bypass) |
| REFMID | 32 | AI | Reference Midpoint (Bypass) |
| REFBQ | 33 | AI | Reference Bottom Quarter Point (Bypass) |
| REFBF | 34 | AI | Reference Bottom Force |
| REFBS | 35 | AI | Reference Bottom Sense |
| AIN | 39, 40 | AI | Analog Input |
| $\mathrm{AV}_{\text {DD }}$ | 37, 42 | P | +5 V Analog Supply |
| $\mathrm{AV}_{\text {ss }}$ | 36, 43, 44 | P | Analog Ground |
| DV ${ }_{\text {DD }}$ | 15, 18, 25, 26 | P | +5 V Digital Supply |
| DV ${ }_{\text {ss }}$ | 13, 14, 17, 27 | P | Digital Ground |
| DRV ${ }_{\text {DD }}$ | 7, 45 | P | +3.3 V/+5 V Digital Supply. Supply for Digital Input and Output Buffers |
| DRV ${ }_{\text {Ss }}$ | 6, 16 | P | +3.3 V/+5 V Digital Ground. Ground for Digital Input and Output Buffers |
| TP1 | 28 | P | Connect to $\mathrm{AV}_{\text {SS }}$ (Analog Ground) |
| TP2 | 48 | P | Connect to DV ${ }_{\text {Ss }}$ (Digital Ground) |
| N/C | 41 |  | No Connect |

TYPE: $\mathrm{AI}=$ Analog Input; $\mathrm{AO}=$ Analog Output; $\mathrm{DI}=$ Digital Input; DO = Digital Output;
P = Power


Equivalent Circuits

PIN CONFIGURATION


ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD875JST | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 48-Pin TQFP <br> AD875JST-Reel <br> $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 48-Pin TQFP <br> (Tape and Reel 13") |

*For outline information see Package Information section.

## TYPICAL CHARACTERISTIC CURVES



Figure 2. Typical DNL


Figure 3. Typical INL

## ABSOLUTE MAXIMUM RATINGS*

| Parameter | With Respect to | Min | Max | Units |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{AV}_{\text {DD }}$ | $\mathrm{AV}_{\text {ss }}$ | -0.5 | +6.5 | Volts |
| $\mathrm{DV}_{\mathrm{DD}}, \mathrm{DRV}_{\text {DD }}$ | $\mathrm{DV}_{\text {Ss }}, \mathrm{DRV}_{\text {ss }}$ | -0.5 | +6.5 | Volts |
| $\mathrm{AV}_{\text {ss }}$ | $\mathrm{DV}_{\text {ss }}, \mathrm{DRV}_{\text {ss }}$ | -0.5 | +0.5 | Volts |
| AIN | $\mathrm{AV}_{\text {Ss }}$ | -0.5 | +6.5 | Volts |
| REFTS, REFTF, REFBS, REFBF | $\mathrm{AV}_{\text {ss }}$ | -0.5 | +6.5 | Volts |
| Digital Inputs, CLK | $\mathrm{DV}_{\text {ss }}, \mathrm{DRV}_{\text {ss }}$ | -0.5 | +6.5 | Volts |
| Junction Temperature |  |  | +150 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature |  | $-65$ | +150 | ${ }^{\circ} \mathrm{C}$ |
| Lead Temperature (10 sec) |  |  | +300 | ${ }^{\circ} \mathrm{C}$ |

*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum ratings for extended periods may affect device reliability.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD875 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


## DEFINITIONS OF SPECIFICATIONS

## Integral Nonlinearity (INL)

Integral nonlinearity refers to the deviation of each individual code from a line drawn from "zero" through "full scale." The point used as "zero" occurs $1 / 2$ LSB before the first code transition. "Full scale" is defined as a level $11 / 2$ LSB beyond the last code transition. The deviation is measured from the center of each particular code to the true straight line.
Differential Nonlinearity (DNL, No Missing Codes)
An ideal ADC exhibits code transitions that are exactly 1 LSB apart. DNL is the deviation from this ideal value. It is often specified in terms of the resolution for which no missing codes (NMC) are guaranteed.

## Offset Error

The first transition should occur at a level $1 / 2$ LSB above "zero." Offset is defined as the deviation of the actual first code transition from that point.

## Gain Error

The first code transition should occur for an analog value $1 / 2$ LSB above nominal negative full scale. The last transition should occur for an analog value $11 / 2$ LSB below the nominal positive full scale. Gain error is the deviation of the actual difference between first and last code transitions and the ideal difference between the first and last code transitions.

## Pipeline Delay (Latency)

The number of clock cycles between conversion initiation and the associated output data being made available. New output data is provided every clock cycle.

## Reference Force/Sense Offset

Resistance between the reference input and comparator input tap points causes offset errors. These errors can be nulled out by using the force-sense connection as shown in the Reference Input section.

## THEORY OF OPERATION

The AD875 uses a pipelined multistage architecture to achieve high sample rate with low power. The multistage approach distributes the conversion over several smaller A/D sub-blocks, refining the conversion with progressively higher accuracy as it passes the results from stage to stage. As a consequence of the distributed conversion, the AD875 requires only a small fraction of the 1023 comparators that would be required in a more traditional 10-bit flash type A/D. A sample-and-hold (SHA) function within each of the stages permits the first stage to operate on a new sample of the input while the second and third stages operate on the two preceding samples. This "assembly line" operation on multiple samples, known as pipelining, allows higher throughput at the cost of some delay, referred to as latency. (See the output timing diagram.)
The detailed operation is as follows: the first stage makes a 4-bit estimate of the analog input voltage by means of the first stage A/D sub-block. The first stage estimate is converted to analog form by the first stage D/A and subtracted from the original input signal. The remainder, or residue, is the difference between the first stage estimate and the actual analog input. Next, the residue is amplified and passed to the second stage where another A/D sub-block makes a 4-bit estimate of its value. Again the analog version of the estimate is subtracted from the signal, and an even finer residue is generated. Finally,
the A/D sub-block in the last stage measures the value of this second stage residue.
The A/D sub-blocks within each stage are actually 4-bit flash converters. Ideally 3 bits in the second and third stages would be sufficient for a 10 -bit A/D. The additional bits allow for digital correction of errors in preceding stages, reducing the tolerances on the sub-block components and making a more robust $\mathrm{A} / \mathrm{D}$. The reference ladders for all three of these flash sub-blocks are wired

Inside the AD875 all signals are processed differentially. This not only enhances the internal dynamic range of the components but provides a high level of noise immunity in a digital environment.

## APPLYING THE AD875 <br> DRIVING THE ANALOG INPUT

The high input resistance and low input capacitance features of the AD875 simplify the current and settling time demands placed on input drive circuitry. Figure 4 shows the equivalent input circuit of the AD875.
The full-scale input range is set by the voltage span, REFTFREFBF (see "Driving the Reference" section). The recommended span should nominally be 2 V peak-to-peak. This span must remain bounded by the minimum and maximum input range (specified in the Analog Input section under DC Specifications). Some example input ranges are given in Table I.


Figure 4. AD875 Equivalent Input Structure
Table I. Input Range Examples

| -Full Scale <br> = REFBF | +Full Scale <br> = REFTF | Input <br> Span |
| :--- | :--- | :--- |
| (V) | (V) | (V) |
| +1.6 | +3.6 | +2.0 |
| +2.0 | +4.0 | +2.0 |
| +2.1 | +4.1 | +2.0 |

While the input impedance of the AD875 is quite high, the switched-capacitor input structure results in a small dynamic input current. In order to prevent gain variations as a result of the input current, maintaining a source impedance of less than or equal to $75 \Omega$ is suggested (Figure 5). In general, a low drive impedance is suggested to minimize noise coupled on the AIN inputs.


Figure 5. Simple AD875 Drive Requirements
For systems which must level shift a ground-referenced signal in order to comply with the input requirements of the AD875, a circuit like Figure 6 is recommended. The suggested op amp, an AD817 or AD818, is configured in inverting mode, where the ac gain of the input signal is -1 . The amount of dc-level shifting is controlled by the dc voltage at the noninverting input of the op amp. The REFBF signal is attenuated by a resistive voltage divider and then multiplied by 2 . In the case where REFBF $=$ 1.6 V , the dc output level will be 2.6 V . The AD817 is a low cost, fast settling, single-supply op amp with a 29 MHz unity gain bandwidth. The AD818 is similar to the AD817 but has a 50 MHz unity gain bandwidth.


Figure 6. DC Level Shift with Gain of $-1 \times$
The AD875 samples the analog input voltage twice: once on the rising edge of the clock (CLK) and once on the falling edge. The first sample, taken on the rising edge, is used to perform a coarse estimate of the input. As indicated in Figure 7, the ana$\log$ input voltage must be settled within $V_{S E}( \pm 16 \mathrm{mV})$ of its final value at this time and must remain within $\mathrm{V}_{\text {SE }}$ until the second sample has been taken. The second sample, taken on the falling edge of the clock, will determine the exact value digitized and should be accurate to within 10 bits $(0.1 \%)$. Note that the actual sample points are delayed by $\mathrm{t}_{\mathrm{S} 1}$ and $\mathrm{t}_{\mathrm{S} 2}$.
For applications where step input signals are expected (i.e., CCD or multiplexed outputs), the settling time of the input drive circuitry should be examined carefully. In most cases, the settling time requirements placed on the input amplifier are easily met by the AD817 or AD818. For higher speed operation, it may be necessary to use faster op amps such as the AD810 or AD811.

As a result of the AD875's settling requirements, there is a maximum slew rate limitation placed on the analog input signal. For applications using CCDs and other sampled analog systems, the AD875 can be used directly. However, for continuous signal applications, Figure 7 implies a maximum slew rate limitation
on the analog input:
Slew Rate of Analog Input (maximum) $=\frac{16 m V}{t_{C H}}(\mathrm{~V} / \mathrm{sec})$
where $t_{C H}$ is the "high" period of the sample clock in seconds, or one-half the full period when the clock is run with $50 \%$ duty cycle. For example, at 15 MHz clock rate, the maximum slew rate is about $0.48 \mathrm{~V} / \mu \mathrm{s}$. This corresponds to a maximum analog input frequency of 76 kHz when a full-scale ( 2 V peak-to-peak) sine wave is used. For input signals with higher slew rates, a sample-and-hold amplifier must be used for accurate digitization.


Figure 7. Analog Input Settling Requirement

## REFERENCE INPUT

## Driving the Reference Terminals

The AD875 requires an external reference on pins REFTF and REFBF. Reference sense pins REFTS and REFBS are also provided for Kelvin connections to minimize voltage drops due to external and internal wiring resistances. A resistor ladder nominally $400 \Omega$ is connected internally between pins REFTF and REFBF.
The voltage drop across the internal resistor ladder determines the input span of the AD875. The driving voltages required at the REFTF and REFBF pins are nominally +4 V and +2 V respectively resulting in a 2 V input span. In order to maintain the requisite 2 V drop across the internal ladder, the external reference must be capable of typically providing 5 mA of dc current.
Transient current flows in and out of the REFTF and REFBF pins. Therefore, a low ac impedance is required at these terminals for proper operation. Bypassing each pin with suitable capacitive decoupling should effectively attenuate any transients. See the AD875 Evaluation Board Schematic for recommended values. Mid (REFMID) and quarter (REFTQ, REFBQ) ladder tap points are also available for additional decoupling if required. It is important to note that these tap points cannot be used to correct integral linearity as is sometimes done in a typical flash converters.

There are several reference configurations suitable for the AD875 depending on the application, desired performance and cost trade-offs. The simplest configuration, shown in Figure 8, utilizes a resistor string to generate the reference voltages from the converter's analog power supply. A $10 \mu \mathrm{~F}$ tantalum capacitor in parallel with a $0.1 \mu \mathrm{~F}$ ceramic capacitor will provide adequate decoupling for both the REFTF and REFBF pins. The $0.1 \mu \mathrm{~F}$ capacitors should be physically located within 1 cm of REFTF and REFBF. A $10 \mu \mathrm{~F}$ capacitor connected between REFTF and REFBF is also recommended for optimum performance. This reference configuration provides the lowest cost
solution but has several disadvantages including poor dc power supply rejection and poor accuracy due to the variability of the internal and external resistor values.


Figure 8. Low Cost Reference Circuit
A higher performance solution employs a voltage regulator to improve dc power supply rejection and absolute accuracy. Figure 9 shows a LM317 adjustable regulator configured to generate a 1.6 V output for REFBF. This output is also used to generate the 3.6 V REFTF signal by multiplying the REFBF signal by 2.25 . Note that the AD817 op amp used to multiply REFBF has been compensated to ensure stability while driving the large capacitive load. The accuracy of this solution is limited by the external resistors and the initial accuracy of the reference.


Figure 9. Reference Circuit with Good PSRR
For optimal performance, a force sense or Kelvin configuration can be used as shown in Figure 10. This circuit uses a highaccuracy reference (AD589) and a dual op amp (OP-295) to maintain accuracy and minimize voltage drops which are generated in the wire connections to the REFTF and REFBF inputs. The output of the AD589 is increased to 1.6 V and 3.6 V at the outputs of the op amps as required. Both op amps are compensated to maintain stability while driving the decoupling capacitors required at the REFTF and REFBF pins.
These outputs, being connected in a feedback loop, tend to cancel any errors caused by the voltage drops in the wires. Note that if the REFTS and REFBS are not used in a force sense configuration, they should be left unconnected and should not be connected to REFTF and REFBF.


Figure 10. High Performance Reference Circuit Using Kelvin Connections

Like any high resolution converter, the layout and decoupling of the reference is critical. The actual voltage digitized by the AD875 is relative to the reference voltages. In Figure 11, for example, the reference returns and the bypass capacitors are connected to the shield of the incoming analog signal. Disturbances in the ground of the analog input, which will be common-mode to the REFTF, REFBF, and AIN pins because of the common ground, are effectively removed by the AD875's high common-mode rejection.
High frequency noise sources, $\mathrm{V}_{\mathrm{N} 1}$ and $\mathrm{V}_{\mathrm{N} 2}$, are shunted to ground by decoupling capacitors. Any voltage drops between the analog input ground and the reference bypassing points will be treated as input signals by the converter via the reference inputs. Consequently, the reference decoupling capacitors should be connected to the same analog ground point used to define the analog input voltage. (For further suggestions, see the "Grounding and Layout Rules" section of the data sheet.)


Figure 11. Recommended Bypassing for the Reference Inputs

## CLOCK INPUT

The AD875 clock input is buffered internally with an inverter powered from the $\mathrm{DRV}_{\mathrm{DD}}$ pin. This feature allows the AD875 to accommodate either +5 V or +3.3 V CMOS logic input signal swings with the input threshold for the CLK pin nominally at $\mathrm{DRV}_{\mathrm{DD}} / 2$.
The AD875's pipelined architecture operates on both rising and falling edges of the input clock. To minimize duty cycle variations the recommended logic family to drive the clock input is high speed CMOS (HC/HCT) logic. HCMOS logic provides both symmetrical voltage threshold levels and sufficient rise and fall times to support 15 MHz operation. The AD875's minimum
clock half cycle may necessitate the use of an external divide-bytwo circuit as shown in Figure 12.


Figure 12. Divide-By-Two Clock Input Circuit
The AD875 is designed to support a conversion rate of 15 MHz ; running the part at slightly faster clock rates may be possible, although at reduced performance levels. Conversely, some slight performance improvements might be realized by clocking the AD875 at slower clock rates.
The power dissipated by the correction logic and output buffers is largely proportional to the clock frequency; running at reduced clock rates provides a reduction in power consumption. Figure 13 illustrates this trade-off.

## DIGITAL INPUTS AND OUTPUTS

Each of the AD875's digital control inputs, MINV, LINV, TEST MODE, THREE-STATE, and STBY is buffered with an inverter powered from the $\mathrm{DRV}_{\mathrm{DD}}$ supply pins. With $\mathrm{DRV}_{\mathrm{DD}}$


Figure 13. Typical Power Dissipation vs. Clock Frequency
set to +5 V all digital inputs readily interface with 5 V CMOS logic. For interfacing with lower voltage CMOS logic, DRV ${ }_{\text {DD }}$ can be set to 3.3 V effectively lowering the nominal input threshold of all digital inputs to $3.3 \mathrm{~V} / 2=1.65 \mathrm{~V}$.

The AD875 provides several convenient digital input pins for controlling the converter output format. By utilizing digital input pins MINV and LINV, three digital output formats are possible: binary, twos complement, and ones complement.
Another element of digital functionality is provided with the TEST MODE pin. To facilitate in-circuit testing of the digital portion of your application, a fixed digital pattern controlled by a digital input is available. For TEST MODE = LOW, an alternating 1010101010 pattern is established. This pattern is further manipulated when used in conjunction with the LINV and MINV pins (see Output Data Format, Table II below).

Table II. Output Data Format

| Approx AIN (V) | MINV | LINV | TEST MODE | THREESTATE | OVR | $\begin{aligned} & \text { (MSB) } \\ & \text { D9 } \end{aligned}$ | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | $\begin{aligned} & \text { (LSB) } \\ & \text { D0 } \end{aligned}$ | UNR |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $>4$ | 0 | 0 | 1 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 |
| 4 | 0 | 0 | 1 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 |
| 3 | 0 | 0 | 1 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 2 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| <2 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |
| X | 0 | 0 | 0 | 0 | ? | 1 | 0 | 1 | 0 | 1 | 0 | 1. | 0 | 1 | 0 | ? |
| $>4$ | 1 | 0 | 1 | 0 | 1 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 |
| 4 | 1 | 0 | 1 | 0 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 |
| 3 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 2 | 1 | 0 | 1 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| <2 | 1 | 0 | 1 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |
| X | 1 | 0 | 0 | 0 | ? | 0 | 0 | 1 | 0 | 1 | 0 | 1 | 0 | 1 | 0 | ? |
| $>4$ | 0 | 1 | 1 | 0 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 4 | 0 | 1 | 1 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 3 | 0 | 1 | 1 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 |
| 2 | 0 | 1 | 1 | 0 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 |
| <2 | 0 | 1 | 1 | 0 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| X | 0 | 1 | 0 | 0 | ? | 1 | 1 | 0 | 1 | 0 | 1 | 0 | 1 | 0 | 1 | ? |
| $>4$ | 1 | 1 |  | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 4 | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 3 | 1 | 1 | 1 | 0 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 |
| 2 | 1 | 1 | 1 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 |
| $<2$ | 1 | 1 | 1 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| X | 1 | 1 | 0 | 0 | ? | 0 | 1 | 0 | 1 | 0 | 1 | 0 | 1 | 0 | 1 | ? |
| $>4$ | X | X | X | 0 | 1 | ? | ? | ? | ? | ? | ? | ? | ? | ? | ? | 0 |
| 2<AIN<4 | X | X | X | 0 | 0 | ? | ? | ? | ? | ? | ? | ? | ? | ? | ? | 0 |
| <2 | X | X | X | 0 | 0 | ? | ? | ? | ? | ? | ? | ? | ? | ? | ? | 1 |
| X | X | X | X | 1 | Z | Z | Z | Z | Z | Z | Z | Z | Z | Z | Z | Z |

Z - High Impedance; $\mathbf{X}$ - Don't Care; ? - Determined By AIN.

Also, a sleep mode feature is provided such that for STBY = HIGH and the clock disabled, the static power of the AD875 will drop below 50 mW . The AD875 reaches rated accuracy 4 clock cycles after STBY is brought LOW and the clock is started.

## DIGITAL OUTPUTS

Each of the on-chip buffers for the AD875 output bits (D0-D9, OVR, UNR) is powered from the $\mathrm{DRV}_{\mathrm{DD}}$ supply pins, separate from $A V_{D D}$ or $D_{D D}$. The output drivers are sized to handle a variety of logic families while minimizing the amount of glitch energy generated. In all cases, a fan-out of one is recommended to keep the capacitive load on the output data bits below the specified 20 pF level.
For $\mathrm{DRV}_{\mathrm{DD}}=5 \mathrm{~V}$, the AD875 output signal swing is compatible with both high speed CMOS and TTL logic families. For TTL, the AD875 on-chip, output drivers were designed to support several of the high speed TTL families (F, AS, S). For applications where the clock rate is below 15 MHz , other TTL families may be appropriate. For interfacing with lower voltage CMOS logic, the AD875 sustains 15 MHz operation with $\mathrm{DRV}_{\mathrm{DD}}=3.3 \mathrm{~V}$. In all cases, check your logic family data sheets for compatibility with the AD875 Digital Specification table.

## THREE-STATE OUTPUTS

The digital outputs of the AD875 can be placed in a high impedance state by setting the THREE-STATE pin to HIGH. This feature is provided to facilitate in-circuit testing or evaluation. Note that this function is not intended for enabling/ diṣabling the ADC outputs from a bus at 15 MHz . Also, to avoid corruption of the sampled analog signal during conversion (three clock cycles), it is highly recommended that the AD875 outputs be enabled on the bus prior to the first sampling. For the purpose of budgetary timing, the maximum access and float delay times ( $\mathrm{t}_{\mathrm{DD}}, \mathrm{t}_{\mathrm{HL}}$ shown in Figure 14) for the AD875 are 150 ns .


Figure 14. High Impedance Output Timing Diagram

## OUT OF RANGE

As Table II indicates, an Underrange (UNR) or Overrange (OVR) condition exists when the analog input voltage is beyond the input range (nominally +2 V to +4 V ) of the converter. UNR (Pin 46) is set LOW when the analog input voltage is within the analog input range. UNR is set HIGH (after accounting for pipeline latency) and will remain HIGH when the analog input voltage is less than the input range by $1 / 2$ LSB from the center of the negative full-scale output code. OVR (Pin 47) is set LOW when the analog input voltage is within the analog input range. OVR is set HIGH (after accounting for pipeline latency) and will remain HIGH when the analog input voltage is greater than the input range by $1 / 2$ LSB from the center of the positive full-scale output code.

## GROUNDING AND LAYOUT RULES

As is the case for any high performance device, proper grounding and layout techniques are essential in achieving optimal performance. The analog and digital grounds on the AD875 have been separated to optimize the management of return currents in a system. It is recommended that a 4-layer printed circuit board (PCB) which employs a ground plane and power planes be used with the AD875. The use of ground and power planes offers distinct advantages:

1. The minimization of the loop area encompassed by a signal and its return path.
2. The minimization of the impedance associated with ground and power paths.
3. The inherent distributed capacitor formed by the power plane, PCB insulation, and ground plane.
These characteristics result in both a reduction of electromagnetic interference (EMI) and an overall improvement in performance.
It is important to design a layout which prevents noise from coupling onto the input signal. Digital signals should not be run in parallel with the input signal traces and should be routed away from the input circuitry.
Separate analog and digital grounds should be joined together directly under the AD875. A solid ground plane under the AD875 is also acceptable if care is taken in the management of the power and ground return currents. A general "rule-ofthumb" for mixed signal layouts dictates that the return currents from digital circuitry should not pass through critical analog circuitry.

## POWER SUPPLY DECOUPLING

The analog and digital supplies of the AD875 have been separated to prevent the typically large transients associated with digital circuitry from coupling into the analog supply ( $\mathrm{AV}_{\mathrm{DD}}$ ). The digital supplies have also been separated into $\mathrm{DRV}_{D D}$ and $\mathrm{DV}_{\text {DD }}$. The $\mathrm{DRV}_{\text {DD }}$ pins provide power for the digital I/O's of the AD875 and are likely to contain high energy transients. Each power supply pin should be decoupled with a $0.1 \mu \mathrm{~F}$ capacitor located as close to the pin as possible. For optimal performance, surface-mount capacitors are recommended. The inductance associated with the leads of through-hole ceramic capacitors typically render them ineffective at higher frequencies. A complete system will also incorporate tantalum capacitors in the $10-100 \mu \mathrm{~F}$ range to decouple low frequency noise and ferrite beads to limit high frequency noise.

## APPLICATIONS <br> IMAGING SYSTEM OVERVIEW

While the specifics of a particular imaging system will vary, most architectures will employ some or all of the building blocks shown in Figure 15. The image sensor, often a charged-coupled device (CCD), transforms light to electrical output. The resultant pixel stream is conditioned by a clamp/sample-hold circuit which is sometimes referred to as a correlated double sampler (CDS). A gain block sets signal levels which maximize the utilization of the dynamic range of the $A / D$ converter. $D C$ restoration is often used to remove any static dc errors which may accumulate over time and temperature. The digitized signal is then processed by the application specific digital signal processor.


Figure 15. Typical Imaging System Block Diagram

For optimum performance the CDS is tailored to the sensor output characteristics. When used in conjunction with a CCD, the CDS acts to remove low frequency signal variations, $\mathrm{kT} / \mathrm{C}$ noise, and other noise components, all of which are artifacts generated by the CCD. The output signal from the CCD is characterized by a series of pixels, each containing both a reset level and the actual video data. Aside from the various noise components, the video data is essentially a stream of stepped dc signals. This pixel stream from the CCD is then ac-coupled through a capacitor to a switch (contained within the CDS block).
This switch, in turn, is connected to a clamp reference voltage. The switch is closed during the reset portion of each pixel. As a result, the difference between the reset level of each pixel and the clamp reference voltage is stored on the coupling capacitor. When the switch is opened, the dc voltage stored on the coupling capacitor sets the dc level for the pixel stream. The video portion of each pixel is then sampled and held using traditional sample/hold (SHA) architectures. Since the CCD noise sources are correlated between the reset and video portions of the pixel stream, and the output of the SHA represents the difference between these two levels, the noise is effectively eliminated.
The output of the CDS will generally require some form of gain control in order to maximize the full-scale input range of the A/D converter. In some applications, a fixed gain may be adequate while in many applications such as camcorders, variable gain control is used to automatically account for variations in scene brightness. Gain control can be achieved using analog or digital techniques and often times must be able to respond at a rate equivalent to the pixel rate. Gilbert multiplier cells and multiplying D/As are two common circuits used for the gain block.
The dc restore block acts to set the final dc level of the signal before digitization by the A/D converter. A fixed voltage level
(equivalent to the black level or negative full scale) generated by the CCD is sampled by the dc restoration circuit usually at the beginning or end of a "scan line." Any difference between the sampled black level and the desired negative full scale is removed either by a servo loop or corrected digitally. To maximize the use of the A/D's input range, the error must be removed prior to the A/D. This is generally accomplished by a high dc-gain feedback path which servos any error detected at the output. The dc restoration effectively removes dc level shifts which may occur as a result of long-term parameter shifts such as component drift and temperature variations.
The main criterion for choosing the $\mathrm{A} / \mathrm{D}$ converter is generally based on resolution and speed. Resolution affects the signals-tonoise ratio of the system, dictates the maximum digital dynamic range of the image, and is a consideration for round-off errors produced in the digital signal processing. The speed of the A/D converter is related to the number of pixel elements and the pixel output rate of the particular image sensor. Multichannel systems may multiplex more than one pixel stream into a single A/D, thus requiring faster conversion rates. Similarly, area CCDs (CCDs which capture video information in two dimensions) operate at higher rates than linear (one dimensional) CCDs.

## MULTICHANNEL IMAGE ACQUISITION SYSTEM

The AD875's fast conversion rate combined with the AD783 sample/hold amplifiers (SHAs) and the AD9300 high speed multiplexer can be used to construct an analog front-end capable of acquiring and digitizing three or more analog signals at a rate of 1 Msps. Figure 16 shows a typical circuit which employs three AD783s capable of acquiring a 2 V p -p step input to 10 -bit accuracy in less than 350 ns .


Figure 16. Multichannel Image Acquisition System

Referring to the timing diagram in Figure 17, the three analog inputs are simultaneously sampled on the falling edge of $\mathrm{S} / \overline{\mathrm{H}}$. After allowing the SHAs to settle ( 250 ns ), the R channel is digitized at the conversion rate of $12 \mathrm{MHz}(83.3 \mathrm{~ns}$ ). Next, the MUX is switched to the G channel, allowed to settle ( 83.3 ns ), and digitized. The B channel is digitized similarly. While the B channel is converted, the R channel data becomes available at the output of the AD875 (due to the pipelined latency). The rising edges of the signals RDAV, GDAV, and BDAV are the signals which indicate when valid data is available at the output of the A/D converter.


Figure 17. Timing Diagram for Figure 16

HIGH SPEED SAMPLE-AND-HOLD AMPLIFIER (SHA)
A sample-hold amplifier is often needed as part of a correlated double sampler or when high bandwidth inputs such as video signals are to be converted by the AD875. For fast, precise sampling required for video signals, an integrated solution such as the AD9101 track-and-hold amplifier is suggested for optimum performance. However, the requirements of many 10 -bit imaging systems can be achieved using a SHA architecture similar to the one shown in Figure 18. This discrete SHA can accurately acquire a 1 V input step within 1 mV accuracy in less than 200 ns . Hold-mode settling within 1 mV is typically less than 50 ns . The resultant throughput rate is 3.3 Msps.


Figure 18. High Speed Discrete SHA

## CIRCUIT DESCRIPTION

The discrete SHA shown in Figure 13 is a closed-loop, noninverting architecture that accepts 1 V p-p inputs. The overall gain of the SHA is +2 in order to accommodate the 2 V input span of the AD875. The AD847, with $0.1 \%$ settling time of 65 ns , is the suggested input buffer to the SHA. The circuit also employs an SD5001 that contains four ultrahigh speed DMOS switches (Q1-Q4). The low cost, fast settling time and high CMRR of the AD817 op amp are critical features necessary for optimal performance and economy.
In sample mode, Q1 and Q3 of the SD5001 are closed (Q2 and Q4 are open). C28 is charged to the input voltage level at a rate primarily determined by the time constant, R9 $\times \mathrm{C} 28$, and the gain ( $2 \times$ ). Simultaneously, C29 is connected to ground through a $250 \Omega$ resistor. If C 28 is equal to C 29 , charge injection from Q1 will be approximately equal to charge injection form Q3 based on the symmetry of the circuit and the inherent matching of the switch capacitance. The resultant pedestal errors appear as a common-mode signal to the AD817 and are approximately canceled from the differential architecture.

In hold mode, Q2 and Q4 are closed (Q1 and Q3 are open) to reduce feedthrough. The AD817 buffers the voltage held on C28 and settles within the requisite 1 mV within 50 ns . The output of the AD817 must then be level-shifted in order to interface with the AD875 input span requirements. Throughput rates greater than 3.3 Msps using this architecture are limited by the $\mathbf{R}_{\mathrm{ON}}$ of the SD5001. Faster sample rates require open-loop architectures or diode-bridge switching in order to reduce the on-resistance.

## TIMING DESCRIPTION

Figure 19 shows the timing requirements for the discrete SHA. The complementary $\mathrm{S} / \overline{\mathrm{H}}$ inputs are HCMOS-compatible although larger gate voltages will improve performance slightly by lowering the on resistances of the DMOS switches. The conversion is started as soon as the output of the SHA has settled within 16 mV of its final value.


Figure 19. Timing Diagram for Discrete SHA

## FEATURES

CMOS 10-Bit 20 MSPS Sampling A/D Converter
Power Dissipation: 140 mW
+5 V Single Supply Operation
Differential Nonlinearity: 0.5 LSB
Guaranteed No Missing Codes
Power Down (Stand-By) Mode
Three-State Outputs
Digital I/Os Compatible with +5 V or +3.3 V Logic
Adjustable Reference Input
Small Size: 28-Pin SOIC or 48-Pin Thin Quad Flatpack (TQFP)

## PRODUCT DESCRIPTION

The AD876 is a CMOS, $140 \mathrm{~mW}, 10$-bit, 20 Msps analog-todigital converter (ADC). The AD876 has an on-chip input sample-and-hold amplifier. The AD876's digital I/Os interface to either +5 V or +3.3 V logic. By implementing a multistage pipelined architecture with output error correction logic, the AD876 offers accurate performance and guarantees no missing codes over the full operating temperature range. To minimize external voltage drops, the reference ladder top and bottom are provided with force and sense pins.
The AD876 can be placed into a standby mode of operation reducing the power below 50 mW . Digital output data can be placed in a high impedance state and is offered in straight binary output.
The AD876's speed, resolution and single supply operation are ideally suited for a variety of applications in video, multimedia, imaging, high speed data acquisition and communications. The AD876's low power and single supply operation are required for high speed portable applications. Its speed and resolution are ideally suited for charge coupled device (CCD) input systems such as color scanners, digital copiers, electronic still cameras and camcorders.
The AD876 is packaged in a space saving 28-pin SOIC and 48pin thin quad flatpack (TQFP) and is specified over the commercial $\left(0^{\circ} \mathrm{C}\right.$ to $\left.+70^{\circ} \mathrm{C}\right)$ temperature range.

## FUNCTIONAL BLOCK DIAGRAM



## PRODUCT HIGHLIGHTS

Low Power: The AD876 at 140 mW consumes a fraction of the power of presently available 10 -bit, video-speed converters.
Power-down mode and single supply operation further enhance its desirability in low power, battery operated applications such as electronic still cameras, camcorders and communication systems.
Very Small Package: The AD876 is available in both a 28 -pin SOIC and 48-pin surface mount, thin quad flat package. The TQFP package is ideal for very tight, low headroom designs.

Digital I/O Functionality: The AD876 offers three-state output control.

This is a preliminary data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.


| Parameter | Min AD876 <br> Typ  | Max | Units |
| :---: | :---: | :---: | :---: |
| RESOLUTION | 10 |  | Bits |
| DC ACCURACY <br> Integral Nonlinearity (INL) Differential Nonlinearity (DNL) No Missing Codes Offset Gain | $\pm 1.0$ $\pm 0.5$ Guaranteed 0.5 1.5 | $\begin{aligned} & \pm 2.0 \\ & \pm 1 \end{aligned}$ | $\begin{aligned} & \text { LSB } \\ & \text { LSB } \\ & \text { \% FSR } \\ & \text { \% FSR } \end{aligned}$ |
| ANALOG INPUT <br> Input Range Input Resistance Input Current Input Capacitance | $\begin{aligned} & 2 \\ & 50 \\ & 60 \\ & 2.4 \end{aligned}$ |  | $\begin{aligned} & \mathrm{V} \mathrm{p}-\mathrm{p} \\ & \mathrm{k} \Omega \\ & \mu \mathrm{~A} \\ & \mathrm{pF} \end{aligned}$ |
| REFERENCE INPUT <br> Reference Top Voltage Reference Bottom Voltage Reference Input Resistance Reference Input Current Reference Top Offset Reference Bottom Offset | 3.5 4.0 <br> 1.8 2.0 <br> TBD 330 <br>  6.0 <br>  25 <br>  25 | $\begin{aligned} & 4.2 \\ & 2.5 \\ & 7.0 \end{aligned}$ | V. <br> V <br> $\Omega$ <br> mA <br> mV <br> mV |
| DYNAMIC PERFORMANCE <br> Effective Number of Bits $\begin{aligned} & \mathrm{f}_{\mathrm{IN}}=1 \mathrm{MHz} \\ & \mathrm{f}_{\mathrm{IN}}=3.58 \mathrm{MHz} \\ & \mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz} \end{aligned}$ <br> Signal-to-Noise and Distortion (S/N+D) Ratio $\begin{aligned} & \mathrm{f}_{\mathrm{IN}}=1 \mathrm{MHz} \\ & \mathrm{f}_{\mathrm{IN}}=3.58 \mathrm{MHz} \\ & \mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz} \end{aligned}$ <br> Total Harmonic Distortion (THD) $\begin{aligned} & \mathrm{f}_{\mathrm{IN}}=1 \mathrm{MHz} \\ & \mathrm{f}_{\mathrm{IN}}=3.58 \mathrm{MHz} \\ & \mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz} \end{aligned}$ <br> Spurious Free Dynamic Range <br> Full Power Bandwidth <br> Intermodulation Distortion (IMD) ${ }^{1}$ <br> Second Order Products <br> Third Order Products <br> Differential Phase <br> Differential Gain | 8.9 <br> 8.2 <br> 56 <br> 51 <br> 60 <br> 58 <br> 54 <br> 62 <br> 250 <br> TBD <br> TBD <br> 0.5 <br> 1 |  | Bits <br> Bits <br> Bits <br> dB <br> dB <br> dB <br> dB <br> dB <br> dB <br> dB <br> MHz <br> dB <br> dB <br> Degree <br> \% |
|  | $\begin{aligned} & +4.5 \\ & +4.5 \\ & +3.0 \end{aligned}$ $\begin{aligned} & 18 \\ & 9 \\ & 1 \end{aligned}$ | $\begin{aligned} & +5.25 \\ & +5.25 \\ & +5.25 \\ & 21 \\ & 12 \\ & 3 \end{aligned}$ | Volts Volts Volts <br> mA mA mA |
| POWER CONSUMPTION | 140 | 170 | mW |
| TEMPERATURE RANGE Specified | 0 | +70 | ${ }^{\circ} \mathrm{C}$ |

## NOTES

${ }^{1} \mathrm{fa}=4.5 \mathrm{MHz}, \mathrm{fb}=5.5 \mathrm{MHz}$
Specifications subject to change without notice. See Definition of Specifications for additional information.

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| Parameter | Symbol | DRV ${ }_{\text {DD }}$ | Min | $\begin{gathered} \text { AD87 } \\ \text { Typ } \end{gathered}$ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| LOGIC INPUT |  |  |  |  |  |  |
| High Level Input Voltage | $\mathrm{V}_{\mathrm{IH}}$ | 3.0 | 2.4 |  |  | V |
|  |  | 5.0 | 4.0 |  |  | V |
|  |  | 5.25 |  | 4.2 |  | V |
| Low Level Input Voltage | $\mathrm{V}_{\text {IL }}$ | 3.0 |  |  | 0.6 | V |
|  |  | 5.0 |  |  | 1.0 | V |
|  |  | 5.25 |  |  | 1.05 | V |
| High Level Input Current | $\mathrm{I}_{\mathrm{IH}}$ | 5.0 | -10 |  | +10 | $\mu \mathrm{A}$ |
| Low Level Input Current | $\mathrm{I}_{\text {IL }}$ | 5.0 | -50 |  | +50 | $\mu \mathrm{A}$ |
| Low Level Input Current (CLK Only) | $\mathrm{I}_{\text {IL }}$ | 5.0 | -10 |  | +10 | $\mu \mathrm{A}$ |
| Input Capacitance | $\mathrm{C}_{\text {IN }}$ |  | 5 |  |  | pF |
| LOGIC OUTPUTS |  |  |  |  |  |  |
| High Level Output Voltage | $\mathrm{V}_{\mathrm{OH}}$ |  | 2.4 |  |  |  |
| $\left(\mathrm{I}_{\mathrm{OH}}=50 \mu \mathrm{~A}\right)$ |  | 3.0 |  |  |  | V |
|  |  | 5.0 | 3.8 |  |  | V |
| ( $\mathrm{I}_{\mathrm{OH}}=0.5 \mathrm{~mA}$ ) |  | 5.0 |  |  |  | V |
| Low Level Output Voltage | $\mathrm{V}_{\text {OL }}$ |  |  |  |  |  |
| ( $\mathrm{I}_{\mathrm{OL}}=50 \mu \mathrm{~A}$ ) |  |  |  |  | 0.7 | V |
|  |  |  |  |  | 1.05 | V |
| ( $\mathrm{I}_{\text {OL }}=0.6 \mathrm{~mA}$ ) |  |  |  |  | 0.4 | V |
| Output Capacitance |  |  |  | 5 |  | pF |
| Output Leakage Current |  |  | -10 |  | 10 | $\mu \mathrm{A}$ |

TIMING SPECIFICATIONS

|  | Symbol | \$ Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Maximum Conversion Rate ${ }^{1}$ |  | 20 |  |  | MHz |
| Clock Period | $\mathrm{t}_{\mathrm{C}}$ |  | 50 |  |  |
| Clock High | $\mathrm{t}_{\mathrm{CH}}$ | 24 | 25 |  | ns |
| Clock Low | $\mathrm{t}_{\mathrm{CL}}$ | 24 | 25 |  | ns |
| Output Delay | $\mathrm{t}_{\text {OD }}$ | 34 | 35 |  | ns |
| Pipeline Delay (Latency) |  |  |  | 4 | Clock Cycles |
| Aperture Delay Time |  |  | TBD |  | ns |
| Aperture Jitter |  |  | TBD |  | ps |

NOTE
${ }^{1}$ Conversion rate is operational down to 10 kHz without degradation in specified performance.


Figure 1. Timing Diagram

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

| Symbol | Pin No. | Type | Name and Function |
| :---: | :---: | :---: | :---: |
| D0 (LSB) | 3 | DO | Least Significant Bit. |
| D1-D8 | 4-11 | DO | Data Bits 1 through 4. |
| D9 (MSB) | 12 | DO | Most Siginificant Bit. |
| THREESTATE | 16 | DI | THREE-STATE $=$ LOW THREE-STATE $=$ HIGH <br> or N/C <br> Normal Operating Mode <br> Outputs High Impedance |
| STBY | 17 | DI | $\frac{\text { STBY }=\text { LOW or N/C }}{\text { Normal Operating Mode }} \quad \underline{\text { STBY }=\text { HIGH }}$ |
| CLK | 15 | DI | Clock Input. |
| CML | 26 | AO | Bypass Pin for an Internal Bias Point. |
| REFTF | 22 | AI | Reference Top Force. |
| REFBF | 24 | AI | Reference Bottom Force. |
| REFTS | 21 | AI | Reference Top Sense. |
| REFBS | 25 | AI | Reference Bottom Sense. |
| AIN | 27 | AI | Analog Input. |
| $\mathrm{AV}_{\text {DD }}$ | 28 | P | +5 V Analog Supply. |
| $\mathrm{AV}_{\text {Ss }}$ | 1, 19 | P | Analog Ground. |
| $\mathrm{DV}_{\mathrm{DD}}$ | 18 | P | +5 V Digital Supply. |
| DV ${ }_{\text {ss }}$ | 14 | P | Digital Ground. |
| DRV ${ }_{\text {DD }}$ | 2 | P | +3.3 V/+5 V Digital Supply. Supply for digital input and output buffers. |
| DRV ${ }_{\text {Ss }}$ | 13 | P | +3.3 V/+5 V Digital Ground. Supply for digital input and output buffers. |
| TP1 | 20 | P | Connect to DV SS. |

Type: $\mathrm{AI}=$ Analog Input; $\mathrm{AO}=$ Analog Output; $\mathrm{DI}=$ Digital Input; $\mathrm{DO}=$ Digital Output; $\mathrm{P}=$ Power.


Three-State, STBY


CLK




AIN


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## FEATURES

Monolithic 14-Bit 2.2 MSPS A/D Converter
Low Power Dissipation: 500 mW
No Missing Codes Guaranteed
Differential Nonlinearity Error: 0.5 LSB
Complete: On-Chip Track-and-Hold Amplifier and Voltage Reference
Signal-to-Noise and Distortion Ratio: $\mathbf{8 0} \mathbf{d B}$
Spurious-Free Dynamic Range: 85 dB
Out-of-Range Indicator
44-Pin PLCC

## PRODUCT DESCRIPTION

The AD878 is a monolithic 14 -bit, 2.2 Msps analog-to-digital converter with an on-chip, high performance sample-and-hold amplifier and voltage reference. The AD878 uses a multistage pipelined architecture with factory programmed calibration circuitry and output error correction logic to provide 14 -bit accuracy at 2.2 Msps data rates. The AD878 combines a merged high speed bipolar/CMOS process and a novel architecture to achieve the resolution and speed of hybrid implementations at a fraction of the power consumption. Additionally, the greater reliability of monolithic construction offers improved system reliability and lower costs than hybrid designs.
The high input impedance, fast-settling input sample-and-hold (S/H) amplifier is well suited for both multiplexed systems that switch negative to positive full-scale voltage levels in successive channels and sampling single-channel inputs at frequencies up to the Nyquist rate. The AD878's wideband input combined with the power and cost savings over previously available hybrids will allow new design opportunities in communications, imaging and medical applications. The AD878 provides both reference output and reference input pins, allowing the onboard reference to serve as a system reference. An external reference can also be substituted to suit the dc accuracy and temperature drift requirements of the application. A single clock input is used to control all internal conversion cycles. The digital output data is presented in binary output format. An out-of-range signal indicates an overflow condition. It can be used with the most significant bit to determine low or high overflow.

## FUNCTIONAL BLOCK DIAGRAM



The AD878 is fabricated on Analog Devices' ABCMOS process which utilizes high speed bipolar and CMOS transistors on a single chip. High speed, precision analog circuits are now combined with high density logic circuits.
The AD878 is packaged in a 44-pin plastic leaded chip carrier (PLCC) package and is specified for operation from $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ and $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.

## PRODUCT HIGHLIGHTS

The AD878 offers a complete single-chip sampling 14-bit, 2.2 Msps analog-to-digital conversion function in a 44 -pin PLCC surface mount package.
Low Power: The AD878 at 650 mW max consumes a fraction of the power of presently available hybrids.
On-Chip Sample-and-Hold (S/H): The high impedance S/H input eliminates the need for external buffers.
Out of Range (OTR): The OTR output bit indicates when the input signal is beyond the AD878's input range.
Ease-of-Use: The AD878 is complete with S/H and voltage reference.

[^24]
## AD878-SPECIFICATIONS

DC SPECIFICATIONS ${ }^{\left(\mathrm{T}_{\text {MIN }} \text { to }\right.} \mathrm{T}_{\text {max }}$ with $\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V}, \mathrm{DV}_{D 0}=+5 \mathrm{~V}, D R V_{D D}=+5 \mathrm{~V}, \mathrm{~V}_{E E}=-5 \mathrm{~V}, \mathrm{f}_{\text {SAMPIE }}=2.2 \mathrm{Msps}$,

| Parameter | J Grade ${ }^{1}$ | A Grade ${ }^{1}$ | Units |
| :---: | :---: | :---: | :---: |
| RESOLUTION | 14 | 14 | Bits min |
| MAX CONVERSION RATE | 2.2 | 2.2 | MHz min |
| ACCURACY <br> Integral Nonlinearity (INL) Differential Nonlinearity (DNL) No Missing Codes Zero Error $\left(@+25^{\circ} \mathrm{C}\right)^{2}$ Gain Error $\left(@+25^{\circ} \mathrm{C}\right)^{2}$ | $\begin{aligned} & \pm 2.5 \\ & \pm 0.5 \\ & 14 \\ & \pm \mathrm{TBD} \\ & \pm \mathrm{TBD} \end{aligned}$ | $\begin{aligned} & \pm 2.5 \\ & \pm 0.5 \\ & 14 \\ & \pm \mathrm{TBD} \\ & \pm \mathrm{TBD} \end{aligned}$ | LSB typ <br> LSB typ <br> Bits Guaranteed <br> \% FSR max <br> \% FSR max |
| TEMPERATURE DRIFT ${ }^{3}$ <br> Zero Error Gain Error ${ }^{3,4}$ Gain Error ${ }^{3,5}$ | $\begin{aligned} & \pm \mathrm{TBD} \\ & \pm \mathrm{TBD} \\ & \pm \mathrm{TBD} \end{aligned}$ | $\begin{aligned} & \pm \mathrm{TBD} \\ & \pm \mathrm{TBD} \\ & \pm \mathrm{TBD} \end{aligned}$ | \% FSR max \% FSR max \% FSR max |
| $\begin{aligned} & \text { POWER SUPPLY REJECTION } \\ & \mathrm{V}_{\mathrm{CC}}(+5 \mathrm{~V} \pm 0.25 \mathrm{~V}) \\ & \mathrm{DV} \\ & \mathrm{~V}_{\mathrm{DD}}(+5 \mathrm{~V} \pm 0.25 \mathrm{~V}) \\ & \mathrm{V}_{\mathrm{EE}}(-5 \mathrm{~V} \pm 0.25 \mathrm{~V}) \\ & \hline \end{aligned}$ | $\begin{aligned} & \pm \mathrm{TBD} \\ & \pm \mathrm{TBD} \\ & \pm \mathrm{TBD} \end{aligned}$ | $\begin{aligned} & \pm \mathrm{TBD} \\ & \pm \mathrm{TBD} \\ & \pm \mathrm{TBD} \end{aligned}$ | \% FSR max <br> \% FSR max <br> \% FSR max |
| ANALOG INPUT <br> Input Range Input Resistance Input Capacitance | $\pm 2.5$ 10 10 | $\pm 2.5$ <br> 10 | Volts max M $\Omega$ typ pF typ |
| INTERNAL VOLTAGE REFERENCE <br> Output Voltage <br> Output Voltage Tolerance <br> Output Current (Available for External Loads) <br> (External Load Should Not Change During Conversion) |  | $\begin{array}{r} 2.5 \\ +25 \\ 2.5 \end{array}$ | Volts typ mV max mA typ |
| REFERENCE INPUT RESISTANCE | 2 | 2 | $\mathrm{k} \Omega \mathrm{typ}$ |
| POWER SUPPLIES |  |  |  |
| Supply Voltages. |  |  |  |
| $\mathrm{V}_{\mathrm{CC}}$ | +5 | +5 | $\mathrm{V}\left( \pm 5 \% \mathrm{~V}_{\mathrm{cc}}\right.$ Operating) |
| $\mathrm{V}_{\text {EE }}$ | -5 | -5 | $\mathrm{V}\left( \pm 5 \% \mathrm{~V}_{\mathrm{EE}}\right.$ Operating) |
| $\mathrm{DV}_{\mathrm{DD}}, \mathrm{DRV}_{\mathrm{DD}}$ | +5 | +5 | $\mathrm{V}\left( \pm 5 \% \mathrm{DV} \mathrm{DD}, \mathrm{DRV}_{\text {DD }}\right.$ Operating) |
| Supply Current |  |  |  |
| $\mathrm{IV}_{\text {cc }}$ | 80 | 80 | mA max |
| $\mathrm{IV}_{\text {EE }}$ | 45 | 45 | mA max |
| $\mathrm{IDRV}_{\mathrm{DD}}, \mathrm{IDV}_{\mathrm{DD}}$ | 5 | 5 | mA max |
| POWER CONSUMPTION | $\begin{aligned} & 500 \\ & 650 \end{aligned}$ | $\begin{aligned} & 500 \\ & 650 \end{aligned}$ | mW typ mW max |

## NOTES

${ }^{1}$ Temperature ranges are as follows: J Grade: $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$; A Grade: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.
${ }^{2}$ Adjustable to zero with external potentiometers (See Zero and Gain Error Calibration section).
${ }^{3}+25^{\circ} \mathrm{C}$ to $\mathrm{T}_{\mathrm{MIN}}$ and $+25^{\circ} \mathrm{C}$ to $\mathrm{T}_{\text {MAX }}$.
${ }^{4}$ Includes internal voltage reference error.
${ }^{5}$ Excludes internal reference drift.
${ }^{6}$ Change in Gain Error as a function of the dc supply voltage.
Specification subject to change without notice.

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.



## NOTES

${ }^{1} \mathrm{f}_{\mathrm{IN}}$ amplitude $=-0.5 \mathrm{~dB}$ full scale unless otherwise indicated. All measurements referred to a $0 \mathrm{~dB}(2.5 \mathrm{~V} \mathrm{pk})$ input signal unless otherwise indicated.
${ }^{2} \mathrm{fa}=100 \mathrm{kHz}, \mathrm{fb}=95 \mathrm{kHz}$ with $\mathrm{f}_{\text {SAMPLE }}=2.2 \mathrm{MHz}$.
Specifications subject to change without notice.
DIGITAL SPECIFICATIONS $\begin{gathered}\left(\mathrm{T}_{\mathrm{MIN}} \text { to } \mathrm{T}_{\text {MAX }} \text { with } \mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V}, \mathrm{DV}_{\mathrm{DD}}=+5 \mathrm{~V}, \mathrm{DRV}_{\mathrm{DD}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-5 \mathrm{~V}, \mathrm{f}_{\text {SAMPIE }}=2.2 \mathrm{Msps} \text {, }, \text { therwise noted) }\right.\end{gathered}$

| Parameters | Symbol | J, A Grades | Units |
| :---: | :---: | :---: | :---: |
| LOGIC INPUTS |  |  |  |
| High Level Input Voltage | $\mathrm{V}_{\mathrm{IH}}$ | +3.8 | $V$ min |
| Low Level Input Voltage | $\mathrm{V}_{\text {IL }}$ | +0.95 | V max |
| High Level Input Current ( $\mathrm{V}_{\mathrm{IN}}=\mathrm{DV}_{\mathrm{DD}}$ ) | $\mathrm{I}_{\mathrm{IH}}$ | $\pm 10$ | $\mu \mathrm{A}$ max |
| Low Level Input Current ( $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ ) | $\mathrm{I}_{\mathrm{IL}}$ | $\pm 10$ | $\mu \mathrm{A}$ max |
| Input Capacitance | $\mathrm{C}_{\text {IN }}$ | 5 | pF typ |
| LOGIC OUTPUTS |  |  |  |
| High Level Output Voltage ( $\mathrm{I}_{\mathrm{OH}}=0.5 \mathrm{~mA}$ ) | $\mathrm{V}_{\mathrm{OH}}$ | +2.4 | V min |
| Low Level Output Voltage ( $\mathrm{I}_{\mathrm{oL}}=1.6 \mathrm{~mA}$ ) | $\mathrm{V}_{\text {oL }}$ | +0.4 | V max |
| Output Capacitance | Cout | 5 | pF typ |

Specifications subject to change without notice.




## NOTES

${ }^{1}$ Conversion rate is operational to TBD without degradation in specified performance.
${ }^{2}$ See Clock Input section for clock periods of TBD ns or greater.
Specifications subject to change without notice.


Figure 1. Timing Diagram

ABSOLUTE MAXIMUM RATINGS*

| Parameter | With <br> Respect to | Min | Max | Units |
| :--- | :--- | :--- | :--- | :--- |
| V $_{\text {CC }}$ | ACOM | -0.5 | +6.5 | Volts |
| V $_{\text {EE }}$ | ACOM | -6.5 | +0.5 | Volts |
| DV $_{\text {DD }}$ | DCOM | -0.5 | +6.5 | Volts |
| DRV | DRCOM | -0.5 | +6.5 | Volts |
| ACOM | DCOM | -1.0 | +1.0 | Volts |
| AINCOM | ACOM | -1.0 | +1.0 | Volts |
| REFCOM | ACOM | -1.0 | +1.0 | Volts |
| DRCOM | DCOM | -1.0 | +1.0 | Volts |
| V $_{\text {CC }}$ | DV | -6.5 | +6.5 | Volts |
| Clock Input | DCOM | -0.5 | $\mathrm{DV}_{\text {DD }}+0.5$ | Volts |
| Digital Outputs | DCOM | -0.5 | $\mathrm{DRV}_{\text {DD }}+0.3$ | Volts |
| AIN, REF IN | AGND | TBD | $\mathrm{TBD}^{2}$ | Volts |
| REF IN | $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{V}_{\mathrm{EE}}$ | 0 | Volts |
| REF IN | $\mathrm{V}_{\mathrm{EE}}$ | 0 | $\mathrm{~V}_{\mathrm{CC}}$ | Volts |
| Junction Temperature |  | +150 | ${ }^{\circ} \mathrm{C}$ |  |
| Storage Temperature | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |  |
| Lead Temperature (10 sec) |  | +300 | ${ }^{\circ} \mathrm{C}$ |  |

*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum ratings for extended periods may effect device reliability.

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

## FEATURES

Conversion Time: $\mathbf{8 0 0}$ ns
1.25 MHz Throughput Rate

Complete: On-Chip Sample-and-Hold Amplifier and Voltage Reference
Low Power Dissipation: 570 mW
No Missing Codes Guaranteed
Signal-to-Noise Plus Distortion Ratio
$\mathrm{f}_{\mathbf{I N}}=100 \mathrm{kHz}: \mathbf{7 0} \mathrm{dB}$
Pin Configurable Input Voltage Ranges
Twos Complement or Offset Binary Output Data 28-Pin DIP and 28-Pin Surface Mount Package Out of Range Indicator

## PRODUCT DESCRIPTION

The AD1671 is a monolithic 12-bit, 1.25 MSPS analog-to-digital converter with an on-board, high performance sample-and-hold amplifier (SHA) and voltage reference. The AD1671 guarantees no missing codes over the full operating temperature range. The combination of a merged high speed bipolar/CMOS process and a novel architecture results in a combination of speed and power consumption far superior to previously available hybrid implementations. Additionally, the greater reliability of monolithic construction offers improved system reliability and lower costs than hybrid designs.
The fast settling input SHA is equally suited for both multiplexed systems that switch negative to positive full-scale voltage levels in successive channels and sampling inputs at frequencies up to and beyond the Nyquist rate. The AD1671 provides both reference output and reference input pins, allowing the on-board reference to serve as a system reference. An external reference can also be chosen to suit the dc accuracy and temperature drift requirements of the application.
The AD1671 uses a subranging flash conversion technique, with digital error correction for possible errors introduced in the first part of the conversion cycle. An on-chip timing generator provides strobe pulses for each of the four internal flash cycles. A single ENCODE pulse is used to control the converter. The digital output data is presented in twos complement or offset binary output format. An out-of-range signal indicates an overflow condition. It can be used with the most significant bit to determine low or high overflow.

## FUNCTIONAL BLOCK DIAGRAM



The performance of the AD1671 is made possible by using high speed, low noise bipolar circuitry in the linear sections and low power CMOS for the logic sections. Analog Devices' ABCMOS-1 process provides both high speed bipolar and 2-micron CMOS devices on a single chip. Laser trimmed thin-film resistors are used to provide accuracy and temperature stability.
The AD1671 is available in two performance grades and three temperature ranges. The AD1671J and K grades are available over the $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ temperature range. The AD1671A grade is available over the $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ temperature range. The AD1671S grade is available over the $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ temperature range.

## PRODUCT HIGHLIGHTS

The AD1671 offers a complete single chip sampling 12-bit, 1.25 MSPS analog-to-digital conversion function in a 28 -pin package.
The AD1671 at 570 mW consumes a fraction of the power of currently available hybrids.
An OUT OF RANGE output bit indicates when the input signal is beyond the AD1671's input range.
Input signal ranges are 0 V to +5 V unipolar or $\pm 5 \mathrm{~V}$ bipolar, selected by pin strapping, with an input resistance of $10 \mathrm{k} \Omega$. The input signal range can also be pin strapped for 0 V to +2.5 V unipolar or $\pm 2.5 \mathrm{~V}$ bipolar with an input resistance of $10 \mathrm{M} \Omega$.

Output data is available in unipolar, bipolar offset or bipolar twos complement binary format.

[^25]
## AD1671 - SPECIFICATIONS

DC SPECIFICATIONS ( $T_{\text {MIN }}$ to $T_{\text {MAX }}$ with $V_{C C}=+5 \mathrm{~V} \pm 5 \%, V_{\text {LOGIC }}=+5 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{E E}=-5 \mathrm{~V} \pm 5 \%$, unless otherwise noted)


## NOTES

${ }^{1}$ Adjustable to zero with external potentiometers.
${ }^{2}$ Includes internal voltage reference error.
${ }^{3}+25^{\circ} \mathrm{C}$ to $\mathrm{T}_{\text {Min }}$ and $+25^{\circ} \mathrm{C}$ to $\mathrm{T}_{\text {MAX }}$.
${ }^{4}$ Excludes internal reference drift.
${ }^{5}$ Change in gain error as a function of the dc supply voltage.
${ }^{6}$ Tested under static conditions. See Figure 15 for typical curve of $I_{\text {LOGIC }}$ vs. load capacitance at maximum $t_{C}$.
Specifications subject to change without notice.

## AC SPECIFICATIONS ${ }^{\left(\mathrm{T}_{\text {MIN }}\right.}$ to $\mathrm{T}_{\text {MAx }}$ with $\mathrm{V}_{\mathrm{cc}}=+5 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\text {Logic }}=+5 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{\mathrm{EE}}=-5 \mathrm{~V} \pm 5 \%, \mathrm{f}_{\text {SAMPLE }}=1 \mathrm{MSPS}$, $\mathrm{f}_{\text {INPuT }}=100 \mathrm{kHz}$, unless otherwise noted) $)^{\text {C }}$

| Parameter | AD1671J/A/S <br> Typ |  | Max | MinAD1671K <br> Typ | Max |
| :--- | :---: | :---: | :---: | :---: | :---: | Units

NOTES
${ }^{1} \mathrm{f}_{\text {IN }}$ amplitude $=-0.5 \mathrm{~dB}(9.44 \mathrm{~V} p-\mathrm{p})$ bipolar mode full scale unless otherwise indicated. All measurements referred to a $0 \mathrm{~dB}( \pm 5 \mathrm{~V})$ input signal, unless otherwise indicated.
${ }^{2} \mathrm{f}_{\mathrm{A}}=99 \mathrm{kHz}, \mathrm{f}_{\mathrm{B}}=100 \mathrm{kHz}$ with $\mathrm{f}_{\text {SAMPLE }}=1 \mathrm{MSPS}$.
Specifications subject to change without notice.


| Parameters | Symbol | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Conversion Time | $\mathrm{t}_{\mathrm{C}}$ |  |  | 800 | ns |
| Sample Rate | $\mathrm{F}_{\text {S }}$ |  |  | 1.25 | Msps |
| ENCODE Pulse Width High (Figure 1a) | $\mathrm{t}_{\text {ENC }}$ | 20 |  | 50 | ns |
| ENCODE Pulse Width Low (Figure 1b) | $\mathrm{t}_{\text {ENCL }}$ | 20 |  |  | ns |
| DAV Pulse Width | $\mathrm{t}_{\text {DAV }}$ | 150 |  | 300 | ns |
| ENCODE Falling Edge Delay | $\mathrm{t}_{\mathrm{F}}$ | 0 |  |  | ns |
| Start New Conversion Delay | $\mathrm{t}_{\mathrm{R}}$ | 0 |  |  | ns |
| Data and OTR Delay from DAV Falling Edge | $\mathrm{t}_{\text {DD }}{ }^{1}$ | 20 | 75 |  | ns |
| Data and OTR Valid before DAV Rising Edge | $\mathrm{tsss}^{2}$ | 20 | 75 |  | ns |

## NOTES

${ }^{1} \mathrm{t}_{\mathrm{DD}}$ is measured from when the falling edge of DAV crosses 0.8 V to when the output crosses 0.4 V or 2.4 V with a 25 pF load capacitor on each output pin.
${ }^{2} \mathrm{t}_{\mathrm{SS}}$ is measured from when the outputs cross 0.4 V or 2.4 V to when the rising edge of DAV crosses 2.4 V with a 25 pF load capacitor on each output pin.
Specifications subject to change without notice.


Figure 1a. Encode Pulse HIGH


Figure 1b. Encode Pulse LOW

PIN DESCRIPTION

| Symbol | Pin No. | Type | Name and Function |
| :---: | :---: | :---: | :---: |
| ACOM | 27 | P | Analog Ground. |
| AIN | 22, 23 | AI | Analog Inputs, AIN1 and AIN2. The AD1671 can be pin strapped for four input ranges: |
| BIT 1 (MSB) | 13 | DO | Most Significant Bit. |
| BIT 2-BIT 11 | 12-3 | DO | Data Bits 2 through 11. |
| BIT 12 (LSB) | 2 | DO | Least Significant Bit. |
| BPO/UPO | 26 | AI | Bipolar or Unipolar Configuration Pin. See section on Input Range Connections for details. |
| DAV | 16 | DO | Data Available Output. The rising edge of DAV indicates an end of conversion and can be used to latch current data into an external register. The falling edge of DAV can be used to latch previous data into an external register. |
| DCOM | 19 | P | Digital Ground. |
| ENCODE | 17 | DI | The analog input is sampled on the rising edge of ENCODE. |
| $\overline{\text { MSB }}$ | 14 | DO | Inverted Most Significant Bit. Provides twos complement output data format. |
| OTR | 15 | DO | Out of Range is Active HIGH when the analog input is out of range. See Output Data Format, Table III. |
| REF COM | 20 | AI | REF COM is the internal reference ground pin. REF COM should be connected as indicated in the Grounding and Decoupling Rules and Optional External Reference Connection Sections. |
| REF IN | 24 | AI | REF IN is the external 2.5 V reference input. |
| REF OUT | 21 | AO | REF OUT is the internal 2.5 V reference output. |
| SHA OUT | 25 | AO | No Connect for bipolar input ranges. Connect SHA OUT to BPO/UPO for unipolar input ranges. |
| $\mathrm{V}_{\text {CC }}$ | 28 | P | +5 V Analog Power. |
| $\mathrm{V}_{\text {EE }}$ | 1 | P | -5 V Analog Power. |
| $\mathrm{V}_{\text {LOGIC }}$ | 18 | P | +5 V Digital Power. |

TYPE: AI $=$ Analog Input; AO $=$ Analog Output; DI $=$ Digital Input; $\mathrm{DO}=$ Digital Output; $\mathbf{P}=$ Power.
PIN CONFIGURATION


## CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are inserted.


## ABSOLUTE MAXIMUM RATINGS ${ }^{\star}$

| Parameter | With Respect to | Min | Max | Units |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | ACOM | -0.5 | +6.5 | Volts |
| $\mathrm{V}_{\text {EE }}$ | ACOM | -6.5 | +0.5 | Volts |
| $\mathrm{V}_{\text {LOGIC }}$ | DCOM | -0.5 | +6.5 | Volts |
| ACOM | DCOM | -1.0 | +1.0 | Volts |
| $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{V}_{\text {LOGIC }}$ | -6.5 | +6.5 | Volts |
| ENCODE | DCOM | -0.5 | $\mathrm{V}_{\text {LOGIC }}+0.5$ | Volts |
| REF IN | ACOM | -0.5 | $\mathrm{V}_{\mathrm{CC}}+0.5$ | Volts |
| AIN | ACOM | -11.0 | +11.0 | Volts |
| BPO/UPO | ACOM | -0.5 | $\mathrm{V}_{\mathrm{CC}}+0.5$ | Volts |
| Junction Temperature |  |  | +150 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature |  | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |
| Lead Temperature ( $10 \mathrm{sec} \mathrm{)}$ |  |  | +300 | ${ }^{\circ} \mathrm{C}$ |

*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum ratings for extended periods may effect device reliability.

ORDERING GUIDE

| Model $^{1}$ | Linearity | Temperature <br> Range | Package <br> Option ${ }^{2,3}$ |
| :--- | :--- | :--- | :--- |
| AD1671JQ | $\pm 2.5 \mathrm{LSB}$ | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{Q}-28$ |
| AD1671KQ | $\pm 2 \mathrm{LSB}$ | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{Q}-28$ |
| AD1671JP | $\pm 2.5 \mathrm{LSB}$ | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{P}-28 \mathrm{~A}$ |
| AD1671KP | $\pm 2 \mathrm{LSB}$ | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{P}-28 \mathrm{~A}$ |
| AD1671AQ | $\pm 2.5 \mathrm{LSB}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-28$ |
| AD1671AP | $\pm 2.5 \mathrm{LSB}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{P}-28 \mathrm{~A}$ |
| AD1671SQ | $\pm 3 \mathrm{LSB}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-28$ |

${ }^{1}$ For details on grade and package offerings screened in accordance with MIL-STD-883, refer to Analog Devices' Military Products Databook or current AD1671/883 data sheet.
${ }^{2} \mathbf{P}=$ Plastic Leaded Chip Carrier; $\mathbf{Q}=$ Cerdip. For outline information see Package Information section.
${ }^{3}$ Analog Devices reserves the right to ship side brazed ceramic packages in lieu of cerdip.

## DEFINITIONS OF SPECIFICATIONS

## INTEGRAL NONLINEARITY (INL)

Integral nonlinearity refers to the deviation of each individual code from a line drawn from "zero" through "full scale." The point used as "zero" occurs $1 / 2$ LSB ( 1.22 mV for a 10 V span) before the first code transition (all zeros to only the LSB on). "Full-scale" is defined as a level $11 / 2$ LSB beyond the last code transition (to all ones). The deviation is measured from the low side transition of each particular code to the true straight line.

## DIFFERENTIAL LINEARITY ERROR (NO MISSING CODES)

An ideal ADC exhibits code transitions that are exactly 1 LSB apart. DNL is the deviation from the ideal value. Thus every code has a finite width. Guaranteed no missing codes to 11 or 12-bit resolution indicates that all 2048 and 4096 codes, respectively, must be present over all operating ranges. No missing codes to 11 bits (in the case of a 12 -bit resolution ADC) also means that no two consecutive codes are missing.

## UNIPOLAR OFFSET

The first transition should occur at a level $1 / 2$ LSB above analog common. Unipolar offset is defined as the deviation of the actual from that point. This offset can be adjusted as discussed later. The unipolar offset temperature coefficient specifies the maxi-
mum change of the transition point over temperature, with or without external adjustments.

## BIPOLAR ZERO

In the bipolar mode the major carry transition ( 011111111111 to 100000000000 ) should occur for an analog value $1 / 2$ LSB below analog common. The bipolar offset error and temperature coefficient specify the initial deviation and maximum change in the error over temperature.

## GAIN ERROR

The last transition (from 111111111110 to 11111111 1111) should occur for an analog value $11 / 2$ LSB below the nominal full scale ( 4.9963 volts for 5.000 volts full scale). The gain error is the deviation of the actual level at the last transition from the ideal level. The gain error can be adjusted to zero as shown in Figures 4 through 7.

## TEMPERATURE COEFFICIENTS

The temperature coefficients for unipolar offset, bipolar zero and gain error specify the maximum change from the initial $\left(+25^{\circ} \mathrm{C}\right)$ value to the value at $\mathrm{T}_{\text {MIN }}$ or $\mathrm{T}_{\text {MAX }}$.

## POWER SUPPLY REJECTION

One of the effects of power supply error on the performance of the device will be a small change in gain. The specifications show the maximum full-scale change from the initial value with the supplies at the various limits.

## DYNAMIC SPECIFICATIONS

SIGNAL-TO-NOISE PLUS DISTORTION (S/N+D) RATIO $\mathrm{S} / \mathrm{N}+\mathrm{D}$ is the ratio of the rms value of the measured input signal to the rms sum of all other spectral components, including harmonics but excluding dc. The value for $\mathrm{S} / \mathrm{N}+\mathrm{D}$ is expressed in decibels.

## EFFECTIVE NUMBER OF BITS (ENOB)

ENOB is calculated from the expression ( $\mathrm{S} / \mathrm{N}+\mathrm{D}$ ) $=6.02 \mathrm{~N}+$ 1.76 dB , where N is equal to the effective number of bits.

## TOTAL HARMONIC DISTORTION (THD)

THD is the ratio of the rms sum of the first six harmonic components to the rms value of the measured input signal and is expressed as a percentage or in decibels.

## INTERMODULATION DISTORTION (IMD)

With inputs consisting of sine waves at two frequencies, fa and fb , any device with nonlinearities will create distortion products of order ( $\mathrm{m}+\mathrm{n}$ ), at sum and difference frequencies of $\mathrm{mfa} \pm$ nfb , where $\mathrm{m}, \mathrm{n}=0,1,2,3 \ldots$ Intermodulation terms are those for which $m$ or $n$ is not equal to zero. For example, the second order terms are ( $\mathrm{fa}+\mathrm{fb}$ ) and ( $\mathrm{fa}-\mathrm{fb}$ ), and the third order terms are ( $2 \mathrm{fa}+\mathrm{fb}$ ), ( $2 \mathrm{fa}-\mathrm{fb}$ ), (fa +2 fb ) and ( $2 \mathrm{fb}-$ fa). The IMD products are expressed as the decibel ratio of the rms sum of the measured input signals to the rms sum of the distortion terms. The two signals are of equal amplitude and the peak value of their sum is -0.5 dB from full scale. The IMD products are normalized to a 0 dB input signal.

PEAK SPURIOUS OR PEAK HARMONIC COMPONENT
The peak spurious or peak harmonic component is the largest spectral component, excluding the input signal and dc. This
value is expressed in decibels relative to the rms value of a fullscale input signal.

## APERTURE DELAY

Aperture delay is the difference between the switch delay and the analog delay of the SHA. This delay represents the point in time, relative to the rising edge of ENCODE input, that the analog input is sampled.

## APERTURE JITTER

Aperture jitter is the variation in aperture delay for successive samples.

## FULL POWER BANDWIDTH

The input frequency at which the amplitude of the reconstructed fundamental is reduced by 3 dB for a full-scale input.

## THEORY OF OPERATION

The AD1671 uses a successive subranging architecture. The analog-to-digital conversion takes place in four independent steps or flashes. The sampled analog input signal is subranged to an intermediate residue voltage for the final 12-bit result by utilizing multiple flashes with subtraction DACs (see the AD1671 functional block diagram).
The AD1671 can be configured to operate with unipolar ( 0 V to $+5 \mathrm{~V}, 0 \mathrm{~V}$ to +2.5 V ) or bipolar ( $\pm 5 \mathrm{~V}, \pm 2.5 \mathrm{~V}$ ) inputs by connecting AIN (Pins 22, 23), SHA OUT (Pin 25) and BPO/ UPO (Pin 26) as shown in Figure 2.


The AD1671 conversion cycle begins by simply providing an active HIGH level on the ENCODE pin (Pin 17). The rising edge of the ENCODE pulse starts the conversion. The falling edge of the ENCODE pulse is specified to operate within a window of time, less than 50 ns after the rising edge of ENCODE or after the falling edge of DAV. The time window prevents digitally coupled noise from being introduced during the final stages of conversion. An internal timing generator circuit accurately controls SHA, flash and DAC timing.
Upon receipt of an ENCODE command the input voltage is held by the front-end SHA and the first 3-bit flash converts the analog input voltage. The 3-bit result is passed to a correction logic register and a segmented current output DAC. The DAC output is connected through a resistor (within the Range/Span Select Block) to SHA OUT. A residue voltage is created by subtracting the DAC output from SHA OUT, which is less than one eighth of the full-scale analog input. The second flash has an input range that is configured with one bit of overlap with the previous DAC. The overlap allows for errors during the flash conversion. The first residue voltage is connected to the second 3-bit flash and to the noninverting input of a high speed, differential, gain of eight amplifier. The second flash result is passed to the correction logic register and to the second segmented current output DAC. The output of the second DAC is connected to the inverting input of the differential amplifier. The differential amplifier output is connected to a two-step, backend, 8 -bit flash. This 8 -bit flash consists of coarse and fine flash converters. The result of the coarse 4-bit flash converter, also configured to overlap one bit of DAC 2, is connected to the correction logic register and selects one of 16 resistors from which the fine 4 -bit flash will establish its span voltage. The fine 4-bit flash is connected directly to the output latches.
The internal timing generator automatically places the SHA into the acquire mode when DAV goes LOW. Upon completion of conversion (when DAV is set HIGH), the SHA has acquired the analog input to the specified level of accuracy and will remain in the sample mode until the next ENCODE command.
The AD1671 will flag an out-of-range condition when the input voltage exceeds the analog input range. OTR (Pin 15) is active HIGH when an out-of-range high or low condition exists. Bits $1-12$ are HIGH when the analog input voltage is greater than the selected input range and LOW when the analog input is less than the selected input range.

## AD1671 DYNAMIC PERFORMANCE

The AD1671 is specified for dc and dynamic performance. A sampling converter's dynamic performance reflects both quantizer and sample-and-hold amplifier (SHA) performance. Quantizer nonlinearities, such as INL and DNL, can degrade dynamic performance. However, a SHA is the critical element which has to accurately sample fast slewing analog input signals. The AD1671's high performance, low noise, patented on-chip SHA minimizes distortion and noise specifications. Nonlinearities are minimized by using a fast slewing, low noise architecture and subregulation of the sampling switch to provide constant offsets (therefore reducing input signal dependent nonlinearities).

Figure 2. AD1671 Input Range Connections

Figure 3 is a typical 2k point Fast Fourier Transform (FFT) plot of a 100 kHz input signal sampled at 1 MHz . The fundamental amplitude is set at -0.5 dB to avoid input signal clipping of offset or gain errors. Note the total harmonic distortion is approximately -81 dB , signal to noise plus distortion is 71 dB and the spurious free dynamic range is 84 dB .


Figure 3. AD1671 FFT Plot, $f_{I N}=100 \mathrm{kHz}$, $f_{\text {SAMPLE }}=1 \mathrm{MHz}$

Figure 4 plots both $\mathrm{S} /(\mathrm{N}+\mathrm{D})$ and Effective Number of Bits (ENOB) for a 100 kHz input signal sampled from 666 kHz to 1.25 MHz.


Figure 4. $S /(N+D)$ vs. Sampling Frequency, $f_{I N}=100 \mathrm{kHz}$
Figure 5 is a THD plot for a full-scale 100 kHz input signal with the sample frequency swept from 666 kHz to 1.25 MHz .


Figure 5. THD vs. Sampling Rate, $f_{I N}=100 \mathrm{kHz}$

The AD1671's SFDR performance is ideal for use in communication systems such as high speed modems and digital radios. The SFDR is better than 84 dB with sample rates up to 1.11 MHz and increases as the input signal amplitude is attenuated by approximately 3 dB . Note also the SFDR is typically better than 80 dB with input signals attenuated by up to -7 dB .


Figure 6. Spurious Free Dynamic Range vs. Sampling Rate, $f_{\mathrm{IN}}=100 \mathrm{kHz}$


Figure 7. Spurious Free Dynamic Range vs. Input Amplitude, $f_{I N}=250 \mathrm{kHz}$

## APPLYING THE AD1671

## GROUNDING AND DECOUPLING RULES

Proper grounding and decoupling should be a primary design objective in any high speed, high resolution system. The AD1671 separates analog and digital grounds to optimize the management of analog and digital ground currents in a system. The AD1671 is designed to minimize the current flowing from REF COM (Pin 20) by directing the majority of the current from $\mathrm{V}_{\mathrm{CC}}(+5 \mathrm{~V}-\mathrm{Pin} 28)$ to $\mathrm{V}_{\mathrm{EE}}$ ( $-5 \mathrm{~V}-\mathrm{Pin} 1$ ). Minimizing ana$\log$ ground currents hence reduces the potential for large ground voltage drops. This can be especially true in systems that do not utilize ground planes or wide ground runs. REF COM is also configured to be code independent, therefore reducing input dependent analog ground voltage drops and errors. Code dependent ground current is diverted to ACOM (Pin 27). Also critical in any high speed digital design is the use of proper digital grounding techniques to avoid potential CMOS "ground bounce." Figure 3 is provided to assist in the proper layout, grounding and decoupling techniques.


Figure 8. AD1671 Grounding and Decoupling

Table I is a list of grounding and decoupling rules that should be reviewed before laying out a printed circuit board.

Table I. Grounding and Decoupling Guidelines

| Power Supply Decoupling | Comment |
| :---: | :---: |
| Capacitor Values | $0.1 \mu \mathrm{~F}$ (Ceramic) and $1 \mu \mathrm{~F}$ (Tantalum) Surface Mount Chip Capacitors Recommended to Reduce Lead Inductance |
| Capacitor Locations | Directly at Positive and Negative Supply Pins to Common Ground Plane |
| Reference (REF OUT) |  |
| Capacitor Value | $1 \mu \mathrm{~F}$ (Tantalum) to ACOM |
| Grounding |  |
| Analog Ground | Ground Plane or Wide Ground Return Connected to the Analog Power Supply |
| Reference Ground (REF COM) | Critical Common Connections Should be Star Connected to REF COM (as Shown in Figure 8) |
| Digital Ground | Ground Plane or Wide Ground Return Connected to the Digital Power Supply |
| Analog and Digital Ground | Connected Together Once at the AD1671 |

## UNIPOLAR ( 0 V TO +5 V) CALIBRATION

The AD1671 is factory trimmed to minimize offset, gain and linearity errors. In some applications the offset and gain errors of the AD1671 need to be externally adjusted to zero. This is accomplished by trimming the voltage at AIN2 (Pin 22). The circuit in Figure 9 is recommended for calibrating offset and gain errors of the AD1671 when configured in the 0 V to +5 V input range. If the offset trim resistor R1 is used, it should be trimmed as follows, although a different offset can be set for a particular system requirement. This circuit will give approximately $\pm 5 \mathrm{mV}$ of offset trim range. Nominally the AD1671 is intended to have a $1 / 2 \mathrm{LSB}$ offset so that the exact analog input for a given code will be in the middle of that code (halfway between the transitions to the codes above it and below it). Thus, the first transition (from 000000000000 to 00000000 0001 ) will occur for an input level of $+1 / 2$ LSB $(0.61 \mathrm{mV}$ for 5 V range).
The gain trim is done by applying a signal $11 / 2$ LSBs below the nominal full scale ( 4.998 V for a 5 V range). Trim R2 to give the last transition (1111 11111110 to 111111111111 ). This circuit will give approximately $\pm 0.5 \% \mathrm{FS}$ of adjustment range.


Figure 9. Unipolar (o $V$ to +5 V) Calibration

## BIPOLAR ( $\pm 5 \mathrm{~V}$ ) CALIBRATION

The connections for the bipolar $\pm 5 \mathrm{~V}$ input range is shown in Figure 10.

Bipolar calibration is similar to unipolar calibration. First, a signal $1 / 2$ LSB above negative full scale $(-4.9988 \mathrm{~V})$ is applied and R1 is trimmed to give the first transition 000000000000 to 000000000001 ). Then a signal $11 / 2$ LSB below positive full scale $(+4.9963 \mathrm{~V})$ is applied and R 2 is trimmed to give the last transition (1111 11111110 to 111111111111 ).


Figure 10. Bipolar ( $\pm 5$ V) Calibration

## UNIPOLAR ( $0 \mathbf{V}$ TO +2.5 V) CALIBRATION

The connections for the 0 V to +2.5 V input range calibration is shown in Figure 11. Figure 11 shows an example of how the offset error can be trimmed in front of the AD1671. The procedure for trimming the offset and gain errors is the same as for the unipolar 5 V range.


Figure 11. Unipolar ( $0 V$ to +2.5 V ) Calibration

BIPOLAR ( $\pm 2.5 \mathrm{~V}$ ) CALIBRATION
The connections for the bipolar $\pm 2.5 \mathrm{~V}$ input range is shown in Figure 12.


Figure 12. Bipolar ( $\pm 2.5$ V) Calibration

## OUTPUT LATCHES

Figure 13 shows the AD1671 connected to the 74 HC 574 octal D-type edge-triggered latches with 3 -state outputs. The latch can drive highly capacitive loads (i.e., bus lines, I/O ports) while maintaining the data signal integrity. The maximum setup and hold times of the 574 type latch must be less than $20 \mathrm{~ns}\left(\mathrm{t}_{\mathrm{DD}}\right.$ and $\mathrm{t}_{\mathrm{ss}}$ minimum). To satisfy the requirements of the 574 type latch the recommended logic families are S, AS, ALS, F or BCT. New data from the AD1671 is latched on the rising edge of the DAV (Pin 16) output pulse. Previous data can be latched by inverting the DAV output with a 7404 type inverter.


Figure 13. AD1671 to Output Latches

## AD1671

## OUT OF RANGE

An out-of-range condition exists when the analog input voltage is beyond the input range $(0 \mathrm{~V}$ to $+2.5 \mathrm{~V}, 0 \mathrm{~V}$ to +5 V , $\pm 2.5 \mathrm{~V}, \pm 5 \mathrm{~V}$ ) of the converter. OTR (Pin 15) is set low when the analog input voltage is within the analog input range. OTR is set HIGH and will remain HIGH when the analog input voltage exceeds the input range by typically $1 / 2$ LSB (OTR transition is tested to $\pm 6$ LSBs of accuracy) from the center of the $\pm$ full-scale output codes. OTR will remain HIGH until the ana$\log$ input is within the input range and another conversion is completed. By logical ANDing OTR with the MSB and its complement, overrange high or underrange low conditions can be detected. Table II is a truth table for the over/under range circuit in Figure 14. Systems requiring programmable gain conditioning prior to the AD1671 can immediately detect an out-ofrange condition, thus eliminating gain selection iterations.

Table II. Out-of-Range Truth Table

| OTR | MSB | Analog Input Is |
| :--- | :--- | :--- |
| 0 | 0 | In Range |
| 0 | 1 | In Range |
| 1 | 0 | Underrange |
| 1 | 1 | Overrange |



Figure 14. Overrange or Underrange Logic

Table III. Output Data Format

| Input <br> Range | Coding | Analog Input ${ }^{1}$ | Digital Output | OTR ${ }^{2}$ |
| :---: | :---: | :---: | :---: | :---: |
| 0 V to +2.5 V | Straight Binary | $\begin{aligned} & \leq-0.0003 \mathrm{~V} \\ & 0 \mathrm{~V} \\ & +2.5 \mathrm{~V} \\ & \geq+2.5003 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 000000000000 \\ & 00000000 \\ & 111111111111 \\ & 1111 \end{aligned} 11111111$ | $\begin{aligned} & 1 \\ & 0 \\ & 0 \\ & 1 \end{aligned}$ |
| 0 V to +5 V | Straight Binary | $\begin{aligned} & \leq-0.0006 \mathrm{~V} \\ & 0 \mathrm{~V} \\ & +5 \mathrm{~V} \\ & \geq+5.0006 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 00000000 \\ & 0000 \\ & 0000 \\ & 1111 \\ & 11111 \\ & 1111 \\ & 11111 \end{aligned} 1111$ | $\begin{aligned} & 1 \\ & 0 \\ & 0 \\ & 1 \end{aligned}$ |
| -2.5 V to +2.5 V | Offset Binary | $\begin{aligned} & \leq-2.5006 \mathrm{~V} \\ & -2.5 \mathrm{~V} \\ & +2.5 \mathrm{~V} \\ & \geq+2.4994 \mathrm{~V} \end{aligned}$ | $\begin{array}{lll} 0000 & 0000 & 0000 \\ 0000 & 0000 & 0000 \\ 1111 & 111111111 \\ 1111 & 1111 & 1111 \end{array}$ | $\begin{aligned} & 1 \\ & 0 \\ & 0 \\ & 1 \end{aligned}$ |
| -5 V to +5 V | Offset Binary | $\begin{aligned} & \leq-5.0012 \mathrm{~V} \\ & -5 \mathrm{~V} \\ & +5 \mathrm{~V} \\ & \geq+4.9988 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 00000000 \\ & 0000000 \\ & 1111 \\ & 111111 \\ & 1111111 \\ & 1111 \end{aligned} 1111$ | $\begin{aligned} & 1 \\ & 0 \\ & 0 \\ & 1 \end{aligned}$ |
| -2.5 V to +2.5 V | Twos Complement (Using $\overline{\text { MSB }}$ ) | $\begin{aligned} & \leq-2.5006 \mathrm{~V} \\ & -2.5 \mathrm{~V} \\ & +2.5 \mathrm{~V} \\ & \geq+2.4994 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 10000000 \\ & 10000000 \\ & 0111 \\ & 0000 \\ & 011111111111 \\ & 01111111 \end{aligned}$ | $\begin{aligned} & 1 \\ & 0 \\ & 0 \\ & 1 \end{aligned}$ |
| -5 V to +5 V | Twos Complement (Using $\overline{\text { MSB }}$ ) | $\begin{aligned} & \leq-5.0012 \mathrm{~V} \\ & -5 \mathrm{~V} \\ & +5 \mathrm{~V} \\ & \geq+4.9988 \mathrm{~V} \end{aligned}$ | $\begin{array}{lll} 1000 & 0000 & 0000 \\ 1000 & 0000 & 0000 \\ 0111 & 1111 & 1111 \\ 0111 & 1111 & 1111 \end{array}$ | $\begin{aligned} & 1 \\ & 0 \\ & 0 \\ & 1 \end{aligned}$ |

NOTES
${ }^{1}$ Voltages listed are with offset and gain errors adjusted to zero.
${ }^{2}$ Typical performance.

## OUTPUT DATA FORMAT

The AD1671 provides both MSB and $\overline{\text { MSB }}$ outputs, delivering data in positive true straight binary for unipolar input ranges and positive true offset binary or twos complement for bipolar input ranges. Straight binary coding is used for systems that accept positive-only signals. If straight binary coding is used with bipolar input signals, a 0 V input would result in a binary output of 2048 . The application software would have to subtract 2048 to determine the true input voltage. Host registers typically perform math on signed integers and assume data is in that format. Twos complement format minimizes software overhead which is especially important in high speed data transfers, such as a DMA operation. The CPU is not bogged down performing data conversion steps, hence the total system throughput is increased.

## OPTIONAL EXTERNAL REFERENCE

The AD1671 includes an on-board +2.5 V reference. The reference input pin (REF IN) can be connected to reference output pin (REF OUT) or a standard external +2.5 V reference can be selected to meet specific system requirements. Fast switching input dependent currents are modulated at the reference input. The reference input voltage can be held with the use of a capacitor. To prevent the AD1671's on-board reference from oscillating when not connected to REF IN, REF OUT must be connected to +5 V . It is possible to connect REF OUT to +5 V due to its output circuit implementation which shuts down the reference.

## I $_{\text {Logic }}$ vs. CONVERSION RATE

Figure 15 is the typical logic supply current vs. conversion rate for various capacitor loads on the digital outputs.


Figure 15. $I_{\text {LOGIC }}$ vs. Conversion Rate for Various Capacitive Loads on the Digital Outputs

## APPLICATIONS

## AD1671 TO ADSP-2100A

Figure 16 demonstrates the AD1671 to ADSP-2100A interface. The 2100 A with a clock frequency of 12.5 MHz can execute an instruction in one 80 ns cycle. The AD1671 is configured to perform continuous time sampling. The DAV output of the AD1671 is asserted at the end of each conversion. DAV can be used to latch the conversion result into the two 574 octal D-latches. The falling edge of the sampling clock is used to generate an interrupt (IRQ3) for the processor. Upon interrupt, the ADSP-2100A starts a data memory read by providing an address on the DMA bus. The decoded address generates OE for the latches and the processor reads their output over the DMA bus. The conversion result is read within a single processor cycle.


Figure 16. AD1671 to ADSP-2100A Interface

## AD1671 TO ADSP-2101/2102

Figure 17 is identical to the 2100 A interface except the sampling clock is used to generate an interrupt (IRQ2) for the processor. Upon interrupt the ADSP-2100A starts a data memory read by providing an address on the address (A) bus. The decode address generates OE for the D-latches and the processor reads their output over the Data (D) bus. Reading the conversion result is thus completed within a single processor cycle.


Figure 17. AD1671 to ADSP-2101/ADSP-2102 Interface

## FEATURES

Complete Monolithic 12-Bit $10 \mu \mathrm{~s}$ Sampling ADC On-Board Sample-and-Hold Amplifier Industry Standard Pinout 8- and 16-Bit Microprocessor Interface
AC and DC Specified and Tested
Unipolar and Bipolar Inputs
$\pm 5 \mathrm{~V}, \pm 10 \mathrm{~V}, 0-10 \mathrm{~V}, 0-20 \mathrm{~V}$ Input Ranges
Commercial, Industrial and Military Temperature Range Grades
MIL-STD-883 and SMD Compliant Versions Available

## PRODUCT DESCRIPTION

The AD1674 is a complete, multipurpose, 12-bit analog-todigital converter, consisting of a user-transparent on-board sample-and-hold amplifier (SHA), 10 volt reference, clock and three-state output buffers for microprocessor interface.
The AD1674 is pin compatible with the industry standard AD574A and AD674A, but includes a sampling function while delivering a faster conversion rate. The on-chip SHA has a wide input bandwidth supporting 12-bit accuracy over the full Nyquist bandwidth of the converter.
The AD1674 is fully specified for ac parameters (such as $\mathrm{S} /(\mathrm{N}+\mathrm{D})$ ratio, THD, and IMD) and dc parameters (offset, full-scale error, etc.). With both ac and dc specifications, the AD1674 is ideal for use in signal processing and traditional dc measurement applications.
The AD1674 design is implemented using Analog Devices' BiMOS II process allowing high performance bipolar analog circuitry to be combined on the same die with digital CMOS logic.
Five different temperature grades are available. The AD1674J and K grades are specified for operation over the $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ temperature range. The A and B grades are specified from $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; the AD1674T grade is specified from $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. The J and K grades are available in both 28 -lead plastic DIP and SOIC. The A and B grade devices are available in 28 -lead hermetically sealed ceramic DIP and 28 -lead SOIC. The T grade is available in 28 -lead hermetically sealed ceramic DIP.

[^26]
## FUNCTIONAL BLOCK DIAGRAM



## PRODUCT HIGHLIGHTS

Industry Standard Pinout: The AD1674 utilizes the pinout established by the industry standard AD574A and AD674A.
Integrated SHA: The AD1674 has an integrated SHA which supports the full Nyquist bandwidth of the converter. The SHA function is transparent to the user; no wait-states are needed for SHA acquisition.
DC and AC Specified: In addition to traditional dc specifications, the AD1674 is also fully specified for frequency domain ac parameters such as total harmonic distortion, signal-to-noise ratio and input bandwidth. These parameters can be tested and guaranteed as a result of the on-board SHA.
Analog Operation: The precision, laser-trimmed scaling and bipolar offset resistors provide four calibrated ranges: 0 to +10 V and 0 to +20 V unipolar, -5 V to +5 V and -10 V to +10 V bipolar. The AD1674 operates on +5 V and $\pm 12 \mathrm{~V}$ or $\pm 15 \mathrm{~V}$ power supplies.
Flexible Digital Interface: On-chip multiple-mode three-state output buffers and interface logic allow direct connection to most microprocessors.
 DC SPECIFICAIIONS $-12 \mathrm{~V} \pm 5 \%$ unless otherwise noted)

| Parameter | Min | AD1674J <br> Typ | Max | Min | AD1674K <br> Typ |
| :--- | :--- | :--- | :--- | :--- | :--- |
| RESOLUTION | 12 |  | Max | Units |  |
| INTEGRAL NONLINEARITY (INL) |  | $\pm 1$ |  |  |  |

## NOTES

${ }^{1}$ Adjustable to zero.
${ }^{2}$ Includes internal voltage reference error.
${ }^{3}$ Maximum change from $25^{\circ} \mathrm{C}$ value to the value at $\mathrm{T}_{\text {min }}$ or $\mathrm{T}_{\text {max }}$.
${ }^{4}$ Reference should be buffered for $\pm 12 \mathrm{~V}$ operation.
All min and max specifications are guaranteed.
Specifications subject to change without notice.

DC SPECIFICATIONS (Continued)

| Parameter | AD1674A |  |  | AD1674B |  |  | AD1674T |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| RESOLUTION | 12 |  |  | 12 |  |  | 12 |  |  | Bits |
| INTEGRAL NONLINEARITY (INL) @ $25^{\circ} \mathrm{C}$ <br> $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ |  |  | $\begin{aligned} & \pm 1 \\ & \pm 1 \end{aligned}$ |  |  | $\begin{aligned} & \pm 1 / 2 \\ & \pm 1 / 2 \end{aligned}$ |  |  | $\begin{aligned} & \pm 1 / 2 \\ & \pm 1 \end{aligned}$ | $\begin{aligned} & \text { LSB } \\ & \text { LSB } \end{aligned}$ |
| DIFFERENTIAL NONLINEARITY (DNL) (No Missing Codes) | 12 |  |  | 12 |  |  | 12 |  |  | Bits |
| UNIPOLAR OFFSET ${ }^{1} @ 25^{\circ} \mathrm{C}$ |  |  | $\pm 2$ |  |  | $\pm 2$ |  |  | $\pm 2$ | LSB |
| BIPOLAR OFFSET ${ }^{1}$ @ $25^{\circ} \mathrm{C}$ |  |  | $\pm 6$ |  |  | $\pm 3$ |  |  | $\pm 3$ | LSB |
| FULL-SCALE ERROR ${ }^{1,2} @ 25^{\circ} \mathrm{C}$ <br> (with Fixed $50 \Omega$ Resistor from REF OUT to REF IN) |  | 0.1 | 0.25 |  | 0.1 | 0.125 |  | 0.1 | 0.125 | \% of FSR |
| TEMPERATURE RANGE | -40 |  | +85 | -40 |  | +85 | -55 |  | +125 | ${ }^{\circ} \mathrm{C}$ |
| TEMPERATURE DRIFT ${ }^{3}$ <br> Unipolar Offset ${ }^{2}$ <br> Bipolar Offset ${ }^{2}$ <br> Full-Scale Error ${ }^{2}$ |  |  | $\begin{aligned} & \pm 2 \\ & \pm 2 \\ & \pm 8 \end{aligned}$ |  |  | $\begin{aligned} & \pm 1 \\ & \pm 1 \\ & \pm 5 \end{aligned}$ |  |  | $\begin{aligned} & \pm 1 \\ & \pm 2 \\ & \pm 7 \end{aligned}$ | $\begin{aligned} & \text { LSB } \\ & \text { LSB } \\ & \text { LSB } \end{aligned}$ |
| POWER SUPPLY REJECTION $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=15 \mathrm{~V} \pm 1.5 \mathrm{~V} \text { or } 12 \mathrm{~V} \pm 0.6 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{LOGIC}}=5 \mathrm{~V} \pm 0.5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{EE}}=-15 \mathrm{~V} \pm 1.5 \mathrm{~V} \text { or }-12 \mathrm{~V} \pm 0.6 \mathrm{~V} \end{aligned}$ |  |  | $\begin{aligned} & \pm 2 \\ & \pm 1 / 2 \\ & \pm 2 \end{aligned}$ |  |  | $\begin{aligned} & \pm 1 \\ & \pm 1 / 2 \\ & \pm 1 \end{aligned}$ |  |  | $\begin{aligned} & \pm 1 \\ & \pm 1 / 2 \\ & \pm 1 \end{aligned}$ | $\begin{aligned} & \text { LSB } \\ & \text { LSB } \\ & \text { LSB } \end{aligned}$ |
| ANALOG INPUT <br> Input Ranges <br> Bipolar <br> Unipolar | $\begin{aligned} & -5 \\ & -10 \\ & 0 \\ & 0 \end{aligned}$ |  | $\begin{aligned} & +5 \\ & +10 \\ & +10 \\ & +20 \end{aligned}$ | $\begin{aligned} & -5 \\ & -10 \\ & 0 \\ & 0 \end{aligned}$ |  | $\begin{aligned} & +5 \\ & +10 \\ & +10 \\ & +20 \end{aligned}$ | $\begin{aligned} & -5 \\ & -10 \\ & 0 \\ & 0 \end{aligned}$ |  | $\begin{aligned} & +5 \\ & +10 \\ & +10 \\ & +20 \end{aligned}$ | Volts <br> Volts <br> Volts <br> Volts |
| Input Impedance 10 Volt Span 20 Volt Span | $\begin{aligned} & 3 \\ & 6 \end{aligned}$ | 5 10 | $\begin{aligned} & 7 \\ & 14 \end{aligned}$ | $\begin{aligned} & 3 \\ & 6 \end{aligned}$ | 5 10 | $\begin{aligned} & 7 \\ & 14 \end{aligned}$ | $\begin{aligned} & 3 \\ & 6 \end{aligned}$ |  | $\begin{aligned} & 7 \\ & 14 \end{aligned}$ | $\begin{aligned} & \mathrm{k} \Omega \\ & \mathrm{k} \Omega \end{aligned}$ |
| POWER SUPPLIES <br> Operating Voltages <br> $V_{\text {Logic }}$ <br> $\mathrm{V}_{\mathrm{Cc}}$ <br> $V_{E E}$ <br> Operating Current <br> $\mathrm{I}_{\text {LOGIC }}$ <br> $\mathrm{I}_{\mathrm{CC}}$ <br> $\mathrm{I}_{\mathrm{EE}}$ | $\begin{aligned} & +4.5 \\ & +11.4 \\ & -16.5 \end{aligned}$ | $\begin{aligned} & 5 \\ & 10 \\ & 14 \end{aligned}$ | $\begin{aligned} & +5.5 \\ & +16.5 \\ & -11.4 \\ & 8 \\ & 14 \\ & 18 \end{aligned}$ | $\begin{aligned} & +4.5 \\ & +11.4 \\ & -16.5 \end{aligned}$ | 5 10 14 | $\begin{aligned} & +5.5 \\ & +16.5 \\ & -11.4 \\ & 8 \\ & 14 \\ & 18 \end{aligned}$ | $\begin{aligned} & +4.5 \\ & +11.4 \\ & -16.5 \end{aligned}$ | $\begin{aligned} & 5 \\ & 10 \\ & 14 \end{aligned}$ | $\begin{aligned} & +5.5 \\ & +16.5 \\ & -11.4 \\ & 8 \\ & 14 \\ & 18 \end{aligned}$ | Volts <br> Volts <br> Volts <br> mA <br> mA <br> mA |
| POWER DISSIPATION |  | 385 | 575 |  | 385 | 575 |  | 385 | 575 | mW |
| INTERNAL REFERENCE VOLTAGE <br> Output Current (Available for External Loads) ${ }^{4}$ <br> (External Load Should Not Change During Conversion) | 9.9 | 10.0 | $\begin{aligned} & 10.1 \\ & 2.0 \end{aligned}$ | 9.9 | 10.0 | $\begin{aligned} & 10.1 \\ & 2.0 \end{aligned}$ | 9.9 | 10.0 | $\begin{aligned} & 10.1 \\ & 2: 0 \end{aligned}$ | Volts mA |

AC SPECIFICATIONS $\begin{aligned} & \left(\mathrm{T}_{\text {min }} \text { to } \mathrm{T}_{\text {max }} \text { with } \mathrm{V}_{\text {or }}=+12 \mathrm{~V} \pm 10 \% \text { or }+12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\text {Loalc }}=+5 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{\text {EE }}=-15 \mathrm{~V} \pm 10 \%\right.\end{aligned}$

| Parameter | AD1674J/A |  |  | AD1674K/B/T |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max |  |
| Signal to Noise and Distortion (S/N+D) Ratio ${ }^{\text {2,3 }}$ | 69 | 70 |  | 70 | 71 |  | dB |
| Total Harmonic Distortion (THD) ${ }^{4}$ |  | -90 | $\begin{aligned} & \hline-82 \\ & 0.008 \end{aligned}$ |  | -90 | $\begin{aligned} & -82 \\ & 0.008 \end{aligned}$ | $\begin{aligned} & \mathrm{dB} \\ & \% \end{aligned}$ |
| Peak Spurious or Peak Harmonic Component |  | -92 | -82 |  | -92 | -82 | dB |
| Full Power Bandwidth |  | 1 |  |  | 1 |  | MHz |
| Full Linear Bandwidth |  | 500 |  |  | 500 |  | kHz |
| Intermodulation Distortion (IMD) ${ }^{5}$ <br> Second Order Products <br> Third Order Products |  | $\begin{aligned} & -90 \\ & -90 \end{aligned}$ | $\begin{aligned} & -80 \\ & -80 \end{aligned}$ |  | $\begin{aligned} & -90 \\ & -90 \end{aligned}$ | $\begin{aligned} & -80 \\ & -80 \end{aligned}$ | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \end{aligned}$ |
| SHA (specifications are included in overall timing specifications) Aperture Delay Aperture Jitter Acquisition Time |  | $\begin{aligned} & 50 \\ & 250 \\ & 1 \end{aligned}$ |  |  | $\begin{aligned} & 50 \\ & 250 \\ & 1 \end{aligned}$ |  | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{ps} \\ & \mu \mathrm{~s} \end{aligned}$ |

DIGITAL SPECIFICATIONS (for all grades $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ with $\mathrm{V}_{\mathrm{cc}}=+15 \mathrm{~V} \pm 10 \%$ or $+12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\text {Logic }}=+5 \mathrm{~V} \pm 10 \%$, $V_{E E}=-15 \mathrm{~V} \pm 10 \%$ or $-12 \mathrm{~V} \pm 5 \%$ )

| Parameter | Test Conditions | Min | Max | Units |
| :---: | :---: | :---: | :---: | :---: |
| LOGIC INPUTS |  |  |  |  |
| $\mathrm{V}_{\mathrm{IH}} \quad$ High Level Input Voltage |  | +2.0 | $\mathrm{V}_{\text {LOGIC }}+0.5 \mathrm{~V}$ | V |
| $\mathrm{V}_{\mathrm{IL}} \quad$ Low Level Input Voltage |  | -0.5 | +0.8 | V |
| $\mathrm{I}_{\mathrm{IH}} \quad$ High Level Input Current ( $\left.\mathrm{V}_{\mathrm{IN}}-5 \mathrm{~V}\right)$ | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {LOGIC }}$ | -10 | +10 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{IL}} \quad$ Low Level Input Current ( $\left.\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}\right)$ | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}$ | -10 | +10 | $\mu \mathrm{A}$ |
| $\mathrm{C}_{\mathrm{IN}} \quad$ Input Capacitance |  |  | 10 | pF |
| LOGIC OUTPUTS |  |  |  |  |
| $\mathrm{V}_{\mathrm{OH}} \quad$ High Level Output Voltage | $\mathrm{I}_{\mathrm{OH}}=0.5 \mathrm{~mA}$ | +2.4 |  | V |
| $\mathrm{V}_{\text {OL }}$ Low Level Output Voltage | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ |  | +0.4 | V |
| $\mathrm{I}_{\mathrm{OZ}} \quad$ High-Z Leakage Current | $\mathrm{V}_{\text {IN }}=0$ to $\mathrm{V}_{\text {LOGIC }}$ | -10 | +10 | $\mu \mathrm{A}$ |
| $\mathrm{C}_{\mathrm{OZ}} \quad$ High-Z Output Capacitance |  |  | 10 | pF |

## NOTES

${ }^{1} \mathrm{f}_{\mathrm{IN}}$ amplitude $=-0.5 \mathrm{~dB}(9.44 \mathrm{~V}$ p-p) 10 V bipolar mode unless otherwise noted. All measurements referred to $-0 \mathrm{~dB}(9.997 \mathrm{~V} p-\mathrm{p})$ input signal unless otherwise noted.
${ }^{2}$ Specified at worst case temperatures and supplies after one minute warm-up.
${ }^{3}$ See Figures 12 and 13 of full-length data sheet for other input frequencies and amplitudes.
${ }^{4}$ See Figure 11 of full-length data sheet.
${ }^{5} \mathrm{fa}=9.08 \mathrm{kHz}, \mathrm{fb}=9.58 \mathrm{kHz}$ with $\mathrm{f}_{\text {SAMPLe }}=100 \mathrm{kHz}$. See Definition of Specifications section and Figure 15.
All min and max specifications are guaranteed.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS*

$\mathrm{V}_{\mathrm{Cc}}$ to Digital Common . . . . . . . . . . . . . . . . . 0 to +16.5 V
$\mathrm{V}_{\mathrm{EE}}$ to Digital Common . . . . . . . . . . . . . . . . . 0 to -16.5 V
$\mathrm{V}_{\text {LOGIC }}$ to Digital Common . . . . . . . . . . . . . . . . . 0 to +7 V
Analog Common to Digital Common . . . . . . . . . . . . . . $\pm 1$ V
Digital Inputs to Digital Common .. -0.5 V to $\mathrm{V}_{\text {LOGIC }}+0.5 \mathrm{~V}$
Analog Inputs to Analog Common . . . . . . . . . . $\mathrm{V}_{\mathrm{EE}}$ to $\mathrm{V}_{\mathrm{CC}}$
$20 \mathrm{~V}_{\text {IN }}$ to Analog Common . . . . . . . . . . . . . . $\mathrm{V}_{\mathrm{EE}}$ to +24 V
REF OUT . . . . . . . . . . . . . . . . Indefinite Short to Common . Momentary Short to $\mathrm{V}_{\mathrm{CC}}$

Junction Temperature . . . . . . . . . . . . . . . . . . . . . . $+175^{\circ} \mathrm{C}$
Power Dissipation . . . . . . . . . . . . . . . . . . . . . . . . 825 mW
Lead Temperature, Soldering . . . . . . . . . . . . . $300^{\circ} \mathrm{C}$, 10 sec
Storage Temperature . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are inserted.


ORDERING GUIDE

| Model $^{\mathbf{1}}$ | Temperature Range | $\mathbf{I N L}$ <br> $\left(\mathbf{T}_{\min }\right.$ <br> to $\left.\mathbf{T}_{\text {max }}\right)$ | $\mathbf{S} /(\mathbf{N}+\mathbf{D})$ <br> $\left(\mathbf{T}_{\boldsymbol{m}}\right.$ to $\left.\mathbf{T}_{\text {max }}\right)$ | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- | :--- | :--- |
| AD1674JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ | 69 dB | Plastic DIP | N-28 |
| AD1674KN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\pm 1 / 2 \mathrm{LSB}$ | 70 dB | Plastic DIP | N-28 |
| AD1674JR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ | 69 dB | Plastic SOIC | R-28 |
| AD1674KR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\pm 1 / 2 \mathrm{LSB}$ | 70 dB | Plastic SOIC | R-28 |
| AD1674AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ | 69 dB | Plastic SOIC | R-28 |
| AD1674BR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1 / 2 \mathrm{LSB}$ | 70 dB | Plastic SOIC | R-28 |
| AD1674AD | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ | 69 dB | Ceramic DIP | D-28 |
| AD1674BD | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1 / 2 \mathrm{LSB}$ | 70 dB | Ceramic DIP | D-28 |
| AD1674TD | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ | 70 dB | Ceramic DIP | D-28 |

NOTES
${ }^{1}$ For details on grade and package offerings screened in accordance with MIL-STD-883, refer to the Analog Devices Military/Aerospace Reference Manual Products Databook or current AD1674/883B data sheet. SMD is also available.
${ }^{2} \mathrm{~N}=$ Plastic DIP; D = Hermetic Ceramic DIP; R = Plastic SOIC. For outline information see Package Information section.

## PIN CONFIGURATION



FEATURES
Autocalibrating
0.002\% THD
$90 \mathrm{~dB} \mathrm{~S} /(\mathrm{N}+\mathrm{D})$
1 MHz Full Power Bandwidth
On-Chip Sample \& Hold Function
$2 \times$ Oversampling for Audio Applications
16-Pin DIP Package
Serial Twos Complement Output Format
Low Input Capacitance-typ 50 pF
AGND Sense for Improved Noise Immunity

## PRODUCTION DESCRIPTION

The AD1876 is a 16 -bit serial output sampling A/D converter which uses a switched capacitor/charge redistribution architecture to achieve a 100 kSPS conversion rate ( $10 \mu \mathrm{~s}$ total conversion time). Overall performance is optimized by digitally correcting internal nonlinearities through on-chip autocalibration.
The circuitry of the AD1876 is partitioned onto two monolithic chips, a digital control chip fabricated with Analog Devices' DSP CMOS process and an analog ADC chip fabricated with the BiMOS II process. Both chips are contained in a single package.
The serial output interface requires an external clock and sample command signal. The output data rate may be as high as 2.08 MHz , and is controlled by the external clock. The twos complement format of the output data is MSB first and is directly compatible with the NPC SM5805 digital decimation filter used in consumer audio products. The AD1876 is also compatible with a variety of DSP processors.

The AD1876 is packaged in a space saving 16-pin plastic DIP and operates from +5 V and $\pm 12 \mathrm{~V}$ supplies; typical power consumption is 235 mW . The digital supply $\left(\mathrm{V}_{\mathrm{DD}}\right)$ is isolated from the linear supplies ( $\mathrm{V}_{\mathrm{EE}}$ and $\mathrm{V}_{\mathrm{CC}}$ ) for reduced digital crosstalk. Separate analog and digital grounds are also provided.

FUNCTIONAL BLOCK DIAGRAM



## NOTES

${ }^{1} \mathrm{~V}_{\text {REF }}=5.00 \mathrm{~V}$; conversion rate $=96 \mathrm{kSPS} ; \mathrm{f}_{\mathrm{IN}}=1.06 \mathrm{kHz} ; \mathrm{V}_{\mathrm{IN}}=-0.05 \mathrm{~dB}$ unless otherwise indicated. All measurements referred to a 0 dB ( $10 \mathrm{~V}_{\mathrm{PP}}$ ) input signal. Values are post calibration.
${ }^{2}$ Includes first 19 harmonics.
${ }^{3}$ Minimum value of $\mathrm{S} /(\mathrm{N}+\mathrm{D})$ corresponds to 5.0 V reference; typical values of $\mathrm{S} /(\mathrm{N}+\mathrm{D})$ correspond to 10.0 V reference.
${ }^{4} \mathrm{f}_{\mathrm{a}}=1008 \mathrm{~Hz} ; \mathrm{f}_{\mathrm{b}}=1055 \mathrm{~Hz}$. See Definition of Specifications section and Figure 14.
${ }^{5}$ See Applications section for recommended voltage reference circuit and Figure 11 for performance with other reference voltage values.
${ }^{6}$ See Applications section for recommended input buffer circuit.
*For explanation of input characteristics, see "Analog Input" section.
Specifications subject to change without notice.
Specifications shown in boldface are tested on all devices at final electrical test at worst case temperature. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested.

## ORDERING GUIDE

| Model | Temperature <br> Range | THD <br> dB | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- | :--- |
| AD1876JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | -95 | Plastic 16-Pin DIP | $\mathrm{N}-16$ |

${ }^{\star} \mathrm{N}=$ Narrow Plastic DIP. For outline information see Package Information section.
\left. DIGITAL SPECIFICATIONS ${\left(T_{\min }{ }^{\text {to }}\right.}^{\max } \mathrm{V}_{\mathrm{Cc}}=+12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{EE}}=-12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{00}=+5 \mathrm{~V} \pm 10 \%\right)$

| Parameter | Test Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| LOGIC INPUTS |  |  |  |  |  |
| $\mathrm{V}_{\text {IH }} \quad$ High Level Input Voltage |  | 2.4 |  |  | V |
| $\mathrm{V}_{\text {IL }} \quad$ Low Level Input Voltage |  | -0.3 |  | 0.8 | V |
| $\mathrm{I}_{\mathrm{IH}} \quad$ High Level Input Current | $\mathrm{V}_{\mathrm{IH}}=\mathrm{V}_{\mathrm{DD}}$ | -10 |  | +10 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{IL}} \quad$ Low Level Input Current | $\mathrm{V}_{\mathrm{IL}}=0 \mathrm{~V}$ | -10 |  | +10 | $\mu \mathrm{A}$ |
| $\mathrm{C}_{\text {IN }} \quad$ Input Capacitance |  |  |  | 10 | pF |
| LOGIC OUTPUTS |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{OH}} \quad$ High Level Output Voltage | $\mathrm{I}_{\mathrm{OH}}=0.1 \mathrm{~mA}$ | $\mathrm{V}_{\mathrm{DD}}-1 \mathrm{~V}$ |  |  | V |
|  | $\mathrm{I}_{\mathrm{OH}}=0.5 \mathrm{~mA}$ | 2.4 |  |  | V |
| $\mathrm{V}_{\text {OL }} \quad$ Low Level Output Voltage | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ |  |  | 0.4 | V |

Specifications subject to change without notice.
Specifications shown in boldface are tested on all devices at final electrical test at worst case temperature. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested.

## ABSOLUTE MAXIMUM RATINGS*


$\left(\mathrm{V}_{\mathrm{EE}}-0.3 \mathrm{~V}\right)$

Soldering . . . . . . . . . . . . . . . . . . . . . . . . . $+300^{\circ} \mathrm{C}$, 10 sec Storage Temperature . . . . . . . . . . . . . . . . $-60^{\circ} \mathrm{C}$ to $+100^{\circ} \mathrm{C}$
*Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## The AD1876 features input protection circuitry consisting of large "distributed" diodes and

 polysilicon series resistors to dissipate both high energy discharges (Human Body Model) and fast, low energy pulses (Charged Device Model). Per Method 3015.2 of MIL-STD-883C, the AD1876 has been classified as a Category 1 Device.Proper ESD precautions are strongly recommended to avoid functional damage or performance
 degradation. Charges as high as 4000 volts readily accumulate on the human body and test equipment, and discharge without detection. Unused devices must be stored in conductive foam or shunts, and the foam discharged to the destination socket before devices are removed. For further information on ESD precaution, refer to Analog Devices' ESD Prevention Manual.

## TIMING SPECIFICATIONS $\left(\mathrm{T}_{\min }\right.$ to $\mathrm{T}_{\max }, \mathrm{V}_{\mathrm{CC}}=+12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{EE}}=-12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{DD}}=+5 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{\mathrm{REF}}=5.00 \mathrm{~V}$ )

| Parameter | Symbol | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Sampling Rate ${ }^{2}$ | $\mathrm{f}_{\mathrm{S}}=1 / \mathrm{t}_{\mathrm{s}}$ | 1 |  | 100 | kSPS |
| Sampling Period ${ }^{2}$ | $\mathrm{t}_{\mathrm{S}}=1 / \mathrm{f}_{\mathrm{s}}$ | 10 |  | 1000 | $\mu \mathrm{s}$ |
| Acquisition Time (Included in $\mathrm{t}_{\mathrm{s}}$ ) | $\mathrm{t}_{\mathrm{A}}$ | 2 |  |  | $\mu \mathrm{s}$ |
| Calibration Time | $\mathrm{t}_{\mathrm{CT}}$ |  |  | 5000 | $\mathrm{t}_{\mathrm{C}}$ |
| CLK Period | $\mathrm{t}_{\mathrm{C}}$ | 480 |  |  | ns |
| CAL to BUSY Delay | $\mathrm{t}_{\text {Calb }}$ | 0 |  |  | ns |
| CLK to BUSY Delay | $\mathrm{t}_{\mathrm{CB}}$ | 50 | 120 | 175 | ns |
| CLK to $\mathrm{D}_{\text {OUt }}$ Hold Time | ${ }^{\text {t }}$ | 10 |  |  | ns |
| CLK HIGH | $\mathrm{t}_{\mathrm{CH}}$ | 160 |  |  | ns |
| CLK LOW | $\mathrm{t}_{\mathrm{CL}}$ | 50 |  |  | ns |
| Dout CLK LOW | $\mathrm{t}_{\mathrm{DCL}}$ | 30 | 80 | 200 | ns |
| SAMPLE LOW to 1st CLK Delay | $\mathrm{t}_{\mathrm{SC}}$ | 50 |  |  | ns |
| CAL HIGH Time | $\mathrm{t}_{\text {CaLh }}$ | 4 |  |  | $\mathrm{t}_{\mathrm{C}}$ |
| CLK to D ${ }_{\text {out }}$ CLK | $\mathrm{t}_{\mathrm{CDH}}$ | 150 | 200 | 275 | ns |
| SAMPLE LOW | $\mathrm{t}_{\text {SL }}$ | 50 |  |  | ns |

## NOTES

${ }^{1}$ See Figure 1 and Figure 2 and the Conversion Control and Autocalibration sections for detailed explanations of the above timing.
${ }^{2}$ Depends upon external clock frequency; includes acquisition time and conversion time. The minimum sampling rate/maximum sampling period is specified to account for droop of the internal sample/hold. Operation at slower rates than specified may degrade performance.

## FEATURES

$2 \mu s$ ADC with Track/Hold 1 $\mu \mathrm{s}$ DAC with Output Amplifier AD7569, Single DAC Output AD7669, Dual DAC Output
On-Chip Bandgap Reference
Fast Bus Interface
Single or Dual 5V Supplies

## GENERAL DESCRIPTION

The AD7569/AD7669 is a complete, 8 -bit, analog I/O system on a single monolithic chip. The AD7569 contains a high speed successive approximation ADC with $2 \mu$ s conversion time, a track/hold with 200 kHz bandwidth, a DAC and output buffer amplifier with $1 \mu \mathrm{~s}$ settling time. A temperature-compensated 1.25 V bandgap reference provides a precision reference voltage for the ADC and the DAC. The AD7669 is similar but contains two DACs with output buffer amplifiers.
A choice of analog input/output ranges is available. Using a supply voltage of +5 V , input and output ranges of zero to 1.25 V and zero to 2.5 volts may be programmed using the RANGE input pin. Using a $\pm 5 \mathrm{~V}$ supply, bipolar ranges of $\pm 1.25 \mathrm{~V}$ or $\pm 2.5 \mathrm{~V}$ may be programmed.
Digital interfacing is via an 8-bit I/O port and standard microprocessor control lines. Bus interface timing is extremely fast, allowing easy connection to all popular 8-bit microprocessors. A separate start convert line controls the track/hold and ADC to give precise control of the sampling period.
The AD7569/AD7669 is fabricated in Linear-Compatible CMOS (LC ${ }^{2}$ MOS), an advanced, mixed technology process combining precision bipolar circuits with low power CMOS logic. The AD7569 is packaged in a 24 -pin, $0.3^{\prime \prime}$ wide "skinny" DIP, a $24-$ terminal SOIC and 28-terminal PLCC and LCCC packages. The AD7669 is available in a 28 -pin, $0.6^{\prime \prime}$ plastic DIP, 28 -terminal SOIC, and 28-terminal PLCC package.


AD7669 FUNCTIONAL BLOCK DIAGRAM


## PRODUCT HIGHLIGHTS

1. Complete Analog I/O on a Single Chip.

The AD7569/AD7669 provides everything necessary to interface a microprocessor to the analog world. No external components or user trims are required, and the overall accuracy of the system is tightly specified, eliminating the need to calculate error budgets from individual component specifications.
2. Dynamic Specifications for DSP Users. In addition to the traditional ADC and DAC specifications the AD7569/AD7669 is specified for AC parameters, including signal-to-noise ratio, distortion and input bandwidth.
3. Fast Microprocessor Interface.

The AD7569/AD7669 has bus interface timing compatible with all modern microprocessors, with bus access and relinquish times less than 75ns and Write pulse width less than 80ns.

# SPECIFICATIONS DAC SPECIFICCTIONS ${ }^{1}$ 

$N_{D O}=+5 \mathrm{~V} \pm 5 \% ; V_{S S}{ }^{2}=$ RANGE $=A G N D_{D C C}=A G N D_{N O C}=D G N D=O V ; R_{L}=2 \mathrm{k} \Omega, C_{L}=100 \mathrm{PF}$ to $A G N D_{D A C}$ unless otherwise stated. Al specifications $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ unless otherwise stated.)

|  |  |  |  |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |

NOTES
${ }^{1}$ Specifications apply to both DACs in the AD7669. V Vut applies to both V OuT $A$ and $V_{\text {OUT }} B$ of the AD7669.
${ }^{2}$ Except where noted, specifications apply for all output ranges including bipolar ranges with dual supply operation.
${ }^{3}$ Temperature ranges are as follows: $\mathrm{J}, \mathrm{K}$ versions; 0 to $+70^{\circ} \mathrm{C}$
$\mathrm{A}, \mathrm{B}$ versions; $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
$\mathrm{S}, \mathrm{T}$ versions; $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
${ }^{4} \mathrm{ILSB}=4.88 \mathrm{mV}$ for 0 to +1.25 V output range, 9.76 mV for 0 to +2.5 V and $\pm 1.25 \mathrm{~V}$ ranges and 19.5 mV for $\pm 2.5 \mathrm{~V}$ range.
${ }^{5}$ See Terminology.
${ }^{6}$ Includes internal voltage reference error and is calculated after offset error has been adjusted out. Ideal unipolar full-scale voltage is (FS - 1LSB); ideal bipolar positive
full-scale voltage is ( $\mathrm{FS} / 2-1 \mathrm{LSB}$ ) and ideal bipolar negative full-scale voltage is $-\mathrm{FS} / 2$.
${ }^{7}$ Sample tested at $25^{\circ} \mathrm{C}$ to ensure compliance.
Specifications subject to change without notice.

## AD/כbY/AD/bby - JFtUIFILAIIUNS ADC SPECIFICATIONS

$N_{D D}=+5 V \pm 5 \% ; V_{S S}{ }^{1}=$ RANGE $=A G N D_{D C C}=A G N D_{N D C}=D G N D=O V ; f_{C U K}=5 M H z$ external unless otherwise stated.
All specifications $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\max }$ unless otherwise stated.) Specifications apply to Mode 1 interface.

|  |  |  |  |  |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |

## NOTES

${ }^{1}$ Except where noted, specifications apply for all ranges including bipolar ranges with dual supply operation.
${ }^{2}$ Temperature ranges are as follows: $\mathrm{J}, \mathrm{K}$ versions; 0 to $+70^{\circ} \mathrm{C}$
$\mathrm{A}, \mathrm{B}$ versions; $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
$\mathrm{S}, \mathrm{T}$ versions $;-50^{\circ}$ to $+125^{\circ} \mathrm{l}$
${ }^{3} 1 \mathrm{LSB}=4.88 \mathrm{mV}$ for 0 to +1.25 V range, 9.76 mV for 0 to +2.5 V and $\pm 1.25 \mathrm{~V}$ ranges and 19.5 mV for $\pm 2.5 \mathrm{~V}$ range.
${ }^{4}$ See Terminology.
${ }^{\text {S }}$ Includes internal voltage reference error and is calculated after offset error has been adjusted out. Ideal unipolar
last code transition occurs at (FS - 3/2LSB); Ideal bipolar last code transition occurs at (FS/2-3/2LSB).
${ }^{6}$ Exact frequencies are 101 kHz and 384 kHz to avoid harmonics coinciding with sampling frequency.
${ }^{7}$ Rising edge of $\overline{B U S Y}$ to falling edge of $\overline{S T}$. The time given refers to the acquisition time which gives a 3 dB
degradation in SNR from the tested figure.
${ }^{8}$ Sample tested at $25^{\circ} \mathrm{C}$ to ensure compliance.
Specifications subject to change without notice.

## CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subjected to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The foam should be discharged to the destination socket before devices are removed.

| Parameter | Limit at $25^{\circ} \mathrm{C}$ (All Grades) | Limit at <br> $\mathrm{T}_{\text {min }}, \mathrm{T}_{\text {max }}$ <br> (J, K, A, B Grades) | Limit at $\mathrm{T}_{\text {min }}, \mathrm{T}_{\text {max }}$ (S, T Grades) | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DAC Timing |  |  |  |  |  |
| $\mathrm{t}_{1}$ | 80 | 80 | 90 | ns min | WR Pulse Width |
| $\mathrm{t}_{2}$ | 0 | 0 | 0 | ns min | $\overline{\mathrm{CS}}, \overline{\mathrm{A}} / \mathrm{B}$ to $\overline{\mathrm{WR}}$ Setup Time |
| $\mathrm{t}_{3}$ | 0 | 0 | 0 | ns min | $\overline{\mathrm{CS}}, \overline{\mathrm{A}} / \mathrm{B}$ to WR Hold Time |
| $\mathrm{t}_{4}$ | 60 | 70 | 80 | ns min | Data Valid to $\overline{W R}$ Setup Time |
| $\mathrm{t}_{5}$ | 10 | 10 | 10 | ns min | Data Valid to $\overline{\text { WR }}$ Hold Time |
| ADC Timing |  |  |  |  |  |
| $\mathrm{t}_{6}$ | 50 | 50 | 50 | ns min | $\overline{\text { ST Pulse Width }}$ |
| $\mathrm{t}_{7}$ | 110 | 130 | 150 | ns max | $\overline{\text { ST }}$ to BUSY Delay |
| $\mathrm{t}_{8}$ | 20 | 30 | 30 | ns max | $\overline{\text { BUSY }}$ to INT Delay |
| $\mathrm{t}_{9}$ | 0 | 0 | 0 | ns min | $\overline{\text { BUSY }}$ to $\overline{\text { CS }}$ Delay |
| $\mathrm{t}_{10}$ | 0 | 0 | 0 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{RD}}$ Setup Time |
| $t_{11}$ | 60 | 75 | 90 | ns min | $\overline{\mathrm{RD}}$ Pulse Width. Determined by $\mathrm{t}_{13}$. |
| $\mathrm{t}_{12}$ | 0 | 0 | 0 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{RD}}$ Hold Time |
| $\mathrm{t}_{13}{ }^{2}$ | 60 | 75 | 90 | ns max | Data Access Time after $\overline{\mathrm{RD}} ; \mathrm{C}_{\mathrm{L}}=20 \mathrm{pF}$ |
|  | 95 | 120 | 135 | ns max | Data Access Time after $\overline{\mathrm{RD}} ; \mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}$ |
| $\mathrm{t}_{14}{ }^{3}$ | 10 | 10 | 10 | ns min | Bus Relinquish Time after $\overline{\mathrm{RD}}$ |
|  | 60 | 75 | 85 | ns max |  |
| $\mathrm{t}_{15}$ | 65 | 75 | 85 | ns max | $\overline{\mathrm{RD}}$ to $\overline{\mathrm{INT}}$ Delay |
| $\mathrm{t}_{16}$ | 120 | 140 | 160 | ns max | $\overline{\mathrm{RD}}$ to $\overline{\text { BUSY }}$ Delay |
| $\mathrm{t}_{17}{ }^{2}$ | 60 | 75 | 90 | ns max | Data Valid Time after $\overline{\text { BUSY }} ; \mathrm{C}_{\mathrm{L}}=20 \mathrm{pF}$ |
|  | 90 | 115 | 135 | ns max | Data Valid Time after $\overline{B U S Y} ; \mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}$ |

## NOTES

${ }^{1}$ Sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance. All input control signals are specified with $\mathrm{t}_{\mathrm{R}}=\mathrm{t}_{\mathrm{F}}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of +5 V ) and timed from a voltage level of 1.6 V .
${ }_{3}^{2} t_{13}$ and $t_{17}$ are measured with the load circuits of Figure 1 and defined as the time required for an output to cross either 0.8 V or 2.4 V .
${ }^{3} \mathrm{t}_{14}$ is defined as the time required for the data line to change 0.5 V when loaded with the circuit of Figure 2.
Specifications subject to change without notice.

a. High-Z to $V_{O H}$

b. High-Z to $V_{O L}$

a. $V_{O H}$ to High-Z

b. $V_{O L}$ to High-Z

Figure 1. Load Circuits for Data Access Time Test

## ABSOLUTE MAXIMUM RATINGS*

$\mathrm{V}_{\mathrm{DD}}$ to $\mathrm{AGND}_{\mathrm{DAC}}$ or $\mathrm{AGND}_{\mathrm{ADC}}$. . . . . . . . $-0.3 \mathrm{~V},+7 \mathrm{~V}$
$\mathrm{V}_{\mathrm{DD}}$ to DGND . . . . . . . . . . . . . . . . . $-0.3 \mathrm{~V},+7 \mathrm{~V}$
$\mathrm{V}_{\mathrm{DD}}$ to $\mathrm{V}_{\mathrm{SS}}$. . . . . . . . . . . . . . . . . . . $-0.3 \mathrm{~V},+14 \mathrm{~V}$
$\mathrm{AGND}_{\mathrm{DAC}}$ or $\mathrm{AGND}_{\mathrm{ADC}}$ to DGND . . $-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
AGND $_{\text {DAC }}$ to AGND $_{\text {ADC }}$. . . . . . . . . . . . . . . . . $\pm 5 \mathrm{~V}$
Logic Voltage to DGND . . . . . . . . $-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
CLK Input Voltage to DGND . . . . $-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
$\mathrm{V}_{\text {out }}\left(\mathrm{V}_{\text {out }} \mathrm{A}, \mathrm{V}_{\text {out }} \mathrm{B}\right.$ ) to
AGND ${ }^{1}{ }_{\text {DAC }} \cdot \cdots \cdot . . . . . . . V_{S s}-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
$\mathrm{V}_{\mathrm{IN}}$ to $\mathrm{AGND}_{\mathrm{ADC}} . . . . . . . . . V_{\mathrm{SS}}-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}$

## NOTE

${ }^{1}$ Output may be shorted to any voltage in the range $V_{S S}$ to $V_{D D}$ provided that the power dissipation of the package is not exceeded. Typical short circuit current for a short to $A G N D$ or $V_{S S}$ is 50 mA .

Figure 2. Load Circuits for Bus Relinquish Time Test

Power Dissipation (Any Package) to $+75^{\circ} \mathrm{C}$. . . . 450 mW Derates above $75^{\circ} \mathrm{C}$ by . . . . . . . . . . . . . . . $6 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ Operating Temperature Range

Commercial (J, K) . . . . . . . . . . . . . . . 0 to $+70^{\circ} \mathrm{C}$
Industrial (A, B) . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Extended (S, T) . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 Secs) . . . . . . . $+300^{\circ} \mathrm{C}$
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other condition above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



LCCC


## AD7669 PIN CONFIGURATIONS

DIP, SOIC


NC = No connect
PLCC


ORDERING GUIDE

| Model | Temperature <br> Range | Relative <br> Accuracy <br> $\mathbf{T}_{\text {MIN }}-\mathbf{T}_{\text {MAx }}$ | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD7569JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ | $\mathrm{N}-24$ |
| AD7569JR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ | $\mathrm{R}-24$ |
| AD7569AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ | $\mathrm{Q}-24$ |
| AD7569SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ | $\mathrm{Q}-24$ |
| AD7569BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 0.5 \mathrm{LSB}$ | $\mathrm{N}-24$ |
| AD7569KN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\pm 0.5 \mathrm{LSB}$ | $\mathrm{N}-24$ |
| AD7569BR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 0.5 \mathrm{LSB}$ | $\mathrm{R}-24$ |
| AD7569BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 0.5 \mathrm{LSB}$ | $\mathrm{Q}-24$ |
| AD7569TQ ${ }^{2}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\pm 1 / 2 \mathrm{LSB}$ | $\mathrm{Q}-24$ |
| AD7569JP | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ | $\mathrm{P}-28 \mathrm{~A}$ |
| AD7569SE | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ | $\mathrm{E}-28 \mathrm{~A}$ |
| AD7569KP | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\pm 1 / 2 \mathrm{LSB}$ | $\mathrm{P}-28 \mathrm{~A}$ |
| AD7569TE ${ }^{2}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\pm 1 / 2 \mathrm{LSB}$ | $\mathrm{E}-28 \mathrm{~A}$ |
| AD7669AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ | $\mathrm{N}-28$ |
| AD7669JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ | $\mathrm{N}-28$ |
| AD7669JP | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ | $\mathrm{P}-28 \mathrm{~A}$ |
| AD7669AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ | $\mathrm{R}-28$ |
| AD7669JR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ | $\mathrm{R}-28$ |

## NOTES

${ }^{1} \mathrm{E}=$ Leadless Ceramic Chip Carrier; $\mathrm{N}=$ Plastic DIP; $\mathbf{P}=$ Plastic Leaded Chip Carrier; $\mathbf{Q}=$ Cerdip; $\mathbf{R}=$ Small Outline SOIC. For outline information see Package Information section.
${ }^{2}$ To order MIL-STD-883, Class B processed parts, add /883B to part number. Contact your local sales office for military data sheet.

## PIN FUNCTION DESCRIPTION

(Applies to the AD7569 and AD7669 unless otherwise stated.)


Table I. Input/Output Ranges LC²MOS

## 5us 8-Bit ADC with Track/Hold

FEATURES
Fast Conversion Time: $\mathbf{5 \mu s}$
On-Chip Track/Hold
Low Total Unadjusted Error: 1LSB
Full Power Signal Bandwidth: 50kHz
Single +5V Supply
100ns Data Access Time
Low Power ( 15 mW typ)
Low Cost
Standard 18-Pin DIPs or 20-Terminal
Surface Mount Packages

FUNCTIONAL BLOCK DIAGRAM


## PRODUCT HIGHLIGHTS

1. Fast Conversion Time/Low Power

The fast, $5 \mu$ s conversion time of the AD7575 makes it suitable for digitizing wideband signals at audio and ultrasonic frequencies, while retaining the advantage of low CMOS power consumption.
2. On-Chip Track/Hold

The on-chip track/hold function is completely self-contained and requires no external hold capacitor. Signals with slew rates up to $386 \mathrm{mV} / \mu \mathrm{s}$ (e.g., 2.46 V peak-to-peak 50 kHz sine waves) can be digitized with full accuracy.
3. Low Total Unadjusted Error

The zero, full-scale and linearity errors of the AD7575 are so low that the total unadjusted error at any point on the transfer function is less than 1LSB and offset and gain adjustments are not required.
4. Single Supply Operation

Operation from a single +5 V supply with a low-cost +1.23 V bandgap reference allows the AD7575 to be used in 5V microprocessor systems without any additional power supplies.
5. Fast Digital Interface

Fast interface timing allows the AD7575 to interface easily to the fast versions of most popular microprocessors such as the $\mathrm{Z} 80 \mathrm{H}, 8085 \mathrm{~A}-2,6502 \mathrm{~B}, 68 \mathrm{~B} 09$ and the DSP processor, the TMS32010.

SDECIFICATIONS ${ }^{\left(V_{D D}\right.}=+5 V, V_{\text {REF }}=+1.23 V$, AGND $=D G N D=O V ; f_{C L K}=4 \mathrm{MHz}$ external;
SPEGIFIGATIN All specifications $\mathrm{T}_{\text {min }}$ to $\mathrm{I}_{\text {max }}$ unless otherwise specified)
AD7575

| Parameter | J, A Versions ${ }^{1}$ | K, B Versions | S Version | T Version | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ```ACCURACY Resolution Total Unadjusted Error Relative Accuracy Minimum Resolution for which No Missing Codes is Guaranteed Full Scale Error \(25^{\circ} \mathrm{C}\) \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) Offset Error \({ }^{2}\) \(25^{\circ} \mathrm{C}\) \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\)``` | $\begin{aligned} & 8 \\ & \pm 2 \\ & \pm 1 \\ & 8 \\ & \pm 1 \\ & \pm 1 \\ & \\ & \pm 1 / 2 \\ & \pm 1 / 2 \end{aligned}$ | $\begin{aligned} & 8 \\ & \pm 1 \\ & \pm 1 / 2 \\ & 8 \\ & \\ & \pm 1 \\ & \pm 1 \\ & \\ & \pm 1 / 2 \\ & \pm 1 / 2 \end{aligned}$ | $\begin{aligned} & 8 \\ & \pm 2 \\ & \pm 1 \\ & 8 \\ & \\ & \pm 1 \\ & \pm 1 \\ & \\ & \pm 1 / 2 \\ & \pm 1 / 2 \end{aligned}$ | $\begin{aligned} & 8 \\ & \pm 1 \\ & \pm 1 / 2 \\ & 8 \\ & \pm 1 \\ & \pm 1 \\ & \\ & \pm 1 / 2 \\ & \pm 1 / 2 \end{aligned}$ | Bits LSB max LSB max Bits max LSB max LSB max LSB max LSB max | Full Scale TC is typically $5 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ <br> Offset TC is typically $5 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ |
| ANALOG INPUT <br> Voltage Range DC Input Impedance Slew Rate, Tracking SNR ${ }^{3}$ | $\begin{aligned} & 0 \text { to } 2 \mathrm{~V}_{\text {REF }} \\ & 10 \\ & 0.386 \\ & 45 \end{aligned}$ | $\begin{aligned} & 0 \text { to } 2 \mathrm{~V}_{\text {REF }} \\ & 10 \\ & 0.386 \\ & 45 \end{aligned}$ | $\begin{aligned} & 0 \text { to } 2 \mathrm{~V}_{\text {REF }} \\ & 10 \\ & 0.386 \\ & 45 \end{aligned}$ | $\begin{aligned} & 0 \text { to } 2 \mathrm{~V}_{\text {REF }} \\ & 10 \\ & 0.386 \\ & 45 \end{aligned}$ | Volts <br> $\mathrm{M} \Omega$ min <br> V/us max <br> dB min | $1 \mathrm{LSB}=2 \mathrm{~V}_{\text {REF }} / 256$; See Figure 16 $\mathrm{V}_{\mathrm{IN}}=2.46 \mathrm{~V} \text { p-p } @ 10 \mathrm{kHz} ; \text { See Figure } 11$ |
| REFERENCEINPUT <br> $\mathbf{V}_{\text {REF }}$ (For specified Performance) <br> $\mathrm{I}_{\text {REF }}$ | $\begin{aligned} & 1.23 \\ & 500 \end{aligned}$ | $\begin{array}{l\|l} 1.23 \\ 500 \end{array}$ | $\begin{array}{l\|l} 1.23 \\ 500 \end{array}$ | $\begin{aligned} & 1.23 \\ & 500 \end{aligned}$ | Volts $\mu \mathrm{A}$ max | $\pm 5 \%$ |
| $\begin{aligned} & \hline \text { LOGIC INPUTS } \\ & \overline{\mathrm{CS}}, \overline{\text { RD }} \\ & \text { V INL }, \text { Input Low Voltage } \\ & \text { V INH }, \text { Input High Voltage } \\ & \mathrm{I}_{\text {IN }}, \text { Input Current } \\ & 25^{\circ} \mathrm{C} \\ & \mathrm{~T}_{\text {min }} \text { to } \mathrm{T}_{\text {max }} \\ & \mathrm{C}_{\text {IN }}, \text { Input Capacitance }{ }^{3} \\ & \hline \end{aligned}$ | $\begin{aligned} & 0.8 \\ & 2.4 \\ & \\ & \pm 1 \\ & \pm 10 \\ & 10 \end{aligned}$ | $\begin{aligned} & 0.8 \\ & 2.4 \\ & \\ & \pm 1 \\ & \pm 10 \\ & 10 \end{aligned}$ | $\begin{aligned} & 0.8 \\ & 2.4 \\ & \\ & \pm 1 \\ & \pm 10 \\ & 10 \end{aligned}$ | $\begin{aligned} & 0.8 \\ & 2.4 \\ & \\ & \pm 1 \\ & \pm 10 \\ & 10 \end{aligned}$ | $V_{\text {max }}$ <br> $V_{\text {min }}$ <br> $\mu \mathrm{A}$ max <br> $\mu \mathrm{A}$ max <br> pF max | $\begin{aligned} & V_{I N}=0 \text { or } V_{D D} \\ & V_{I N}=0 \text { or } V_{D D} \end{aligned}$ |
| CLK <br> $\mathrm{V}_{\text {INL }}$, Input Low Voltage <br> $\mathrm{V}_{\text {INH }}$, Input High Voltage <br> $\mathrm{I}_{\text {INL }}$, Input Low Current $I_{\text {INH }}$, Input High Current | $\begin{aligned} & 0.8 \\ & 2.4 \\ & 700 \\ & 700 \\ & \hline \end{aligned}$ | $\begin{array}{\|l} 0.8 \\ 2.4 \\ 700 \\ 700 \\ \hline \end{array}$ | $\begin{aligned} & 0.8 \\ & 2.4 \\ & 800 \\ & 800 \\ & \hline \end{aligned}$ | $\begin{aligned} & 0.8 \\ & 2.4 \\ & 800 \\ & 800 \end{aligned}$ | $V_{\text {max }}$ <br> $V$ min <br> $\mu \mathrm{A}$ max <br> $\mu A$ max | $\begin{aligned} & \mathrm{V}_{\mathrm{INL}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{INH}}=\mathrm{V}_{\mathrm{DD}} \end{aligned}$ |
| LOGIC OUTPUTS <br> $\overline{\text { BUSY }}, \mathrm{DB} 0$ to DB7 <br> $\mathrm{V}_{\mathrm{OL}}$, Output Low Voltage <br> $\mathrm{V}_{\mathrm{OH}}$, Output High Voltage <br> DB0 to DB7 <br> Floating State Leakage Current <br> Floating State Output Capacitance ${ }^{3}$ | $\begin{aligned} & 0.4 \\ & 4.0 \\ & \pm 1 \\ & 10 \end{aligned}$ | $\left\lvert\, \begin{gathered} 0.4 \\ 4.0 \\ \\ \pm 1 \\ 10 \end{gathered}\right.$ | $\begin{aligned} & 0.4 \\ & 4.0 \\ & \\ & \pm 10 \\ & 10 \end{aligned}$ | $\begin{aligned} & 0.4 \\ & 4.0 \\ & \pm 10 \\ & 10 \end{aligned}$ | $V_{\text {max }}$ <br> $V_{\text {min }}$ <br> $\mu A \max$ pF max | $\begin{aligned} & I_{\text {SINK }}=1.6 \mathrm{~mA} \\ & I_{\text {SOURCE }}=40 \mu \mathrm{~A} \\ & \mathrm{~V}_{\text {OUT }}=0 \text { to } V_{\text {DD }} \end{aligned}$ |
| $\begin{aligned} & \hline \text { CONVERSION TIME }{ }^{4} \\ & \text { With External Clock } \\ & \text { With Internal Clock, } \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \end{aligned}$ | $\begin{aligned} & 5 \\ & 5 \\ & 15 \end{aligned}$ | $\left\lvert\, \begin{aligned} & 5 \\ & 5 \\ & 15 \end{aligned}\right.$ | $\left\lvert\, \begin{aligned} & 5 \\ & 5 \\ & 15 \end{aligned}\right.$ | $\begin{aligned} & 5 \\ & 5 \\ & 15 \\ & \hline \end{aligned}$ | $\mu \mathrm{s}$ $\mu \mathrm{s}$ min $\mu s$ max | $\mathrm{f}_{\mathrm{CLK}}=4 \mathrm{MHz}$ <br> Using recommended clock components shown in Figure 15. |
| POWER REQUIREMENTS ${ }^{5}$ <br> $V_{D D}$ <br> IDD <br> Power Dissipation <br> Power Supply Rejection | $\begin{aligned} & +5 \\ & 6 \\ & 15 \\ & \pm 1 / 4 \end{aligned}$ | $\begin{aligned} & +5 \\ & 6 \\ & 15 \\ & \pm 1 / 4 \end{aligned}$ | $\begin{aligned} & +5 \\ & 7 \\ & 15 \\ & \pm 1 / 4 \end{aligned}$ | $\begin{aligned} & +5 \\ & 7 \\ & 15 \\ & \pm 1 / 4 \end{aligned}$ | Volts <br> mA max <br> mW typ <br> LSB max | $\pm 5 \%$ for Specified Performance <br> Typically 3 mA with $\mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V}$ $4.75 \mathrm{~V} \leq \mathrm{V}_{\mathrm{DD}} \leq 5.25 \mathrm{~V}$ |

## NOTES

${ }^{\prime}$ Temperature Ranges are as follows:
J, K Versions; 0 to $+70^{\circ} \mathrm{C}$
A, B Versions; $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
S, T Versions; $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
${ }^{2}$ Offset error is measured with respect to an ideal first code transition which occurs at 1/2LSB.
${ }^{3}$ Sample tested at $25^{\circ} \mathrm{C}$ to ensure compliance.
${ }^{4}$ Accuracy may degrade at conversion times other than those specified.
${ }^{\text {'Power supply }}$ current is measured when AD7575 is inactive i.e. when $\overline{\mathbf{C S}}=\overline{\mathbf{R D}}=\overline{\mathbf{B U S Y}}=$ logic HIGH.
Specifications subject to change without notice.

AD7575
TIMING SPECIFICATIONS ${ }^{1}$

$$
N_{D O}=+5 V, V_{R E F}=+1.23 V, A G N D=D G N D=O V
$$

| Parameter | Limit at $+25^{\circ} \mathrm{C}$ <br> (All Versions) | Limit at $\mathrm{T}_{\text {min }}, \mathrm{T}_{\text {max }}$ (J, K, A, B Versions) | Limit at $T_{\text {min }}, T_{\text {max }}$ (S, T Versions) | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{1}$ | 0 | 0 | 0 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{RD}}$ Setup Time |
| $\mathrm{t}_{2}$ | 100 | 100 | 120 | ns max | $\overline{\mathrm{RD}}$ to BUSY Propagation Delay |
| $\mathrm{t}_{3}{ }^{2}$ | 100 | 100 | 120 | ns max | Data Access Time after $\overline{\mathrm{RD}}$ |
| $\mathrm{t}_{4}$ | 100 | 100 | 120 | ns min | $\overline{\mathrm{RD}}$ Pulse Width |
| $\mathrm{t}_{5}$ | 0 | 0 | 0 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{RD}}$ Hold Time |
| $\mathrm{t}_{6}{ }^{2}$ | 80 | 80 | 100 | ns max | Data Access Time after $\overline{\text { BUSY }}$ |
| $\mathrm{t}_{7}{ }^{3}$ | 10 | 10 | 10 | $n s \min$ | Data Hold Time |
|  | 80 | 80 | 100 | ns max |  |
| $\mathrm{t}_{8}$ | 0 | 0 | 0 | ns min | $\overline{\text { BUSY }}$ to $\overline{\mathrm{CS}}$ Delay |

## NOTES

${ }^{1}$ Timing Specifications are sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance. All input control signals are specified with $\mathbf{t r}=\mathbf{t f}=\mathbf{2 0 n s}(\mathbf{1 0 \%}$ to $90 \%$ of $+5 \mathrm{~V})$ and timed from a voltage level of 1.6 V .
${ }^{2} \mathrm{t}_{3}$ and $\mathrm{t}_{6}$ are measured with the load circuits of Figure 1 and defined as the time required for an output to cross 0.8 V or 2.4 V .
${ }^{3} \mathrm{t}_{7}$ is defined as the time required for the data lines to change 0.5 V when loaded with the circuits of Figure 2.
Specifications subject to change without notice.

## Test Circuits


a. High-Z to $V_{O H}$

b. High-Z to $V_{O L}$

a. $V_{O H}$ to High-Z

b. $V_{O L}$ to High-Z

Figure 2. Load Circuits for Data Hold Time Test

## ABSOLUTE MAXIMUM RATINGS*

| $\mathrm{V}_{\mathrm{DD}}$ to AGND | 7 V |
| :---: | :---: |
| $\mathrm{V}_{\mathrm{DD}}$ to DGND | -0.3V, +7V |
| AGND to DGND | $-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}$ |
| Digital Input Voltage to DGND | $-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| Digital Output Voltage to DGND | $-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| CLK Input Voltage to DGND | $-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| $\mathrm{V}_{\text {Ref }}$ to AGND | $-0.3 \mathrm{~V}, \mathrm{~V}_{\text {DD }}$ |
| AIN to AGND | $-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}$ |
| Operating Temperature Range |  |
| Commercial (J, K Versions) | 0 to $+70^{\circ} \mathrm{C}$ |
| Industrial (A, B Versions) | $25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Extended (S, T Versions) |  |

Storage Temperature Range . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10sec) . . . . . . . . . $+300^{\circ} \mathrm{C}$
Power Dissipation (Any Package) to $+75^{\circ} \mathrm{C}$. . . . . 450 mW
Derates above $+75^{\circ} \mathrm{C}$ by . . . . . . . . . . . . . . . $6 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are removed.

## PIN CONFIGURATIONS



NC = NO CONNECT


ORDERING GUIDE

|  | Temperature <br> Range | Relative <br> Accuracy <br> (LSB) | Package <br> Options |
| :--- | :--- | :--- | :--- |
| AD7575JN | 0 to $+70^{\circ} \mathrm{C}$ | $\pm 1 \max$ | $\mathrm{~N}-18$ |
| AD7575KN | 0 to $+70^{\circ} \mathrm{C}$ | $\pm 1 / 2 \max$ | $\mathrm{~N}-18$ |
| AD7575JP | 0 to $+70^{\circ} \mathrm{C}$ | $\pm 1$ max | $\mathrm{P}-20 \mathrm{~A}$ |
| AD7575KP | 0 to $+70^{\circ} \mathrm{C}$ | $\pm 1 / 2 \max$ | $\mathrm{P}-20 \mathrm{~A}$ |
| AD7575AQ | $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1 \max$ | $\mathrm{Q}-18$ |
| AD7575BQ | $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1 / 2 \max$ | $\mathrm{Q}-18$ |
| AD7575SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\pm 1 \max$ | $\mathrm{Q}-18$ |
| AD7575TQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\pm 1 / 2 \max$ | $\mathrm{Q}-18$ |
| AD7575SE | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\pm 1$ max | $\mathrm{E}-20 \mathrm{~A}$ |
| AD7575TE | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\pm 1 / 2 \max$ | $\mathrm{E}-20 \mathrm{~A}$ |

NOTES
${ }^{1}$ To order MIL-STD-883, Class B process parts, add /883B to part number. Contact local sales office for military data sheet. For U.S. Standard Military Drawing (SMD), see DESC drawing \#5962-87762.
${ }^{2} \mathbf{E}=$ Leadless Ceramic Chip Carrier; $\mathbf{N}=$ Plastic DIP; $\mathbf{P}=$ Plastic Leaded Chip Carrier; $\mathbf{Q}=$ Cerdip. For outline information see Package Information section.

## TERMINOLOGY

## LEAST SIGNIFICANT BIT (LSB)

An ADC with 8-bits resolution can resolve 1 part in $2^{8}$ (i.e., 256) of full scale. For the AD7575 with +2.46 V full scale one LSB is 9.61 mV .

## TOTAL UNADJUSTED ERROR

This is a comprehensive specification which includes full scale error, relative accuracy and offset error.

## RELATIVE ACCURACY

Relative Accuracy is the deviation of the ADC's actual code transition points from a straight line drawn between the devices measured first LSB transition point and the measured full scale transition point.

## SNR

Signal-to-Noise Ratio (SNR) is the ratio of the desired signal to the noise produced in the sampled and digitized analog signal. SNR is dependent on the number of quantization levels used in the digitization process; the more levels, the smaller the quantization noise. The theoretical SNR for a sine wave input is given by
$\mathrm{SNR}=(6.02 \mathrm{~N}+1.76) \mathrm{dB}$
where N is the number of bits in the ADC.

## FULL SCALE ERROR (GAIN ERROR)

The gain of a unipolar ADC is defined as the difference between the analog input levels required to produce the first and the last digital output code transitions. Gain error is a measure of the deviation of the actual span from the ideal span of FS - 2LSB's.

## ANALOG INPUT RANGE

With $\mathrm{V}_{\text {REF }}=+1.23 \mathrm{~V}$ the maximum analog input voltage range is 0 to +2.46 V . The output data in LSB's is related to the analog input voltage by the integer value of the following expression:

Data (LSB's) $=\frac{256 \text { AIN }}{2 \mathrm{~V}_{\text {REF }}}+0.5$

## SLEW RATE

Slew Rate is the maximum allowable rate of change of input signal such that the digital sample values are not in error. Slew Rate limitations may restrict the analog signal bandwidth for full-scale analog signals below the bandwidth allowed from sampling theorem considerations.

FEATURES<br>Monolithic 16-Bit ADC<br>0.0015\% Linearity Error<br>On-Chip Self-Calibration Circuitry<br>Programmable Low Pass Filter<br>0.1 Hz to 10 Hz Corner Frequency<br>0 to +2.5 V or $\pm 2.5 \mathrm{~V}$ Analog Input Range<br>4 kSPS Output Data Rate<br>Flexible Serial Interface<br>Ultralow Power<br>\section*{APPLICATIONS}<br>Industrial Process Control<br>Weigh Scales<br>Portable Instrumentation<br>Remote Data Acquisition

## GENERAL DESCRIPTION

The AD7701 is a 16 -bit ADC which uses a sigma delta conversion technique. The analog input is continuously sampled by an analog modulator whose mean output duty cycle is proportional to the input signal. The modulator output is processed by an on-chip digital filter with a six-pole Gaussian response, which updates the output data register with 16 -bit binary words at word rates up to 4 kHz . The sampling rate, filter corner frequency and output word rate are set by a master clock input that may be supplied externally, or by a crystal-controlled onchip clock oscillator.

The inherent linearity of the ADC is excellent, and end-point accuracy is ensured by self-calibration of zero and full-scale which may be initiated at any time. The self-calibration scheme can also be extended to null system offset and gain errors in the input channel.
The output data is accessed through a flexible serial port, which has an asynchronous mode compatible with UARTs and two synchronous modes suitable for interfacing to shift registers or the serial ports of industry-standard microcontrollers.
CMOS construction insures low power dissipation, and a power down mode reduces the idle power consumption to only $10 \mu \mathrm{~W}$.

## FUNCTIONAL BLOCK DIAGRAM



## PRODUCT HIGHLIGHTS

1. The AD7701 offers 16 -bit resolution coupled with outstanding $0.0015 \%$ accuracy.
2. No missing codes ensures true, usable, 16 -bit dynamic range, removing the need for programmable gain and level-setting circuitry.
3. The effects of temperature drift are eliminated by on-chip self-calibration, which removes zero and gain error. External circuits can also be included in the calibration loop to remove system offsets and gain errors.
4. A flexible synchronous/asynchronous interface allows the AD7701 to interface directly to UARTs or to the serial ports of industry-standard microcontrollers.
5. Low operating power consumption and an ultralow power standby mode make the AD7701 ideal for loop-powered remote sensing applications, or battery-powered portable instruments.

This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

SPECIFICATIONS ${ }_{7 \text { ficki }}=4.096 \mathrm{MHz}$; Bipolar Mode; MODE $=+5 \mathrm{~V}$; $\mathrm{A}_{1 \mathrm{~N}}$ Source Resistance $=$
AD7701 $750 \Omega^{1}$ with 1 nF to AGND at $A_{1 N}$, unless otherwise stated.)


| Parameter | A, S Versions ${ }^{\text {2 }}$ | B, T Versions ${ }^{\mathbf{2}}$ | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: |
| POWER REQUIREMENTS ${ }^{8}$ |  |  |  |  |
| Power Supply Voltages |  |  |  |  |
| Analog Positive Supply ( $\mathrm{AV}_{\mathrm{DD}}$ ) | 4.5/5.5 | 4.5/5.5 | $V \min / V \max$ |  |
| Digital Positive Supply ( $\mathrm{DV}_{\mathrm{DD}}$ ) | $4.5 / \mathrm{AV}_{\mathrm{DD}}$ | $4.5 / \mathrm{AV}_{\text {DD }}$ | $V \min / V \max$ |  |
| Analog Negative Supply ( $\mathrm{AV}_{\text {ss }}$ ) | -4.5/-5.5 | -4.5/-5.5 | $V \min / \mathrm{Vmax}$ |  |
| Digital Negative Supply ( $\mathrm{DV}_{\text {ss }}$ ) | -4.5/-5.5 | -4.5/-5.5 | Vmin/Vmax |  |
| Calibration Memory Retention |  |  |  |  |
| Power Supply Voltage | 2.0 | 2.0 | V min |  |
| DC Power Supply Currents ${ }^{8}$ |  |  |  |  |
| Analog Positive Supply ( $\mathrm{AI}_{\mathrm{DD}}$ ) | 2.7 | 2.7 | mA max | Typically 2 mA |
| Digital Positive Supply ( $\mathrm{DI}_{\mathrm{DD}}$ ) | 2 | 2 | mA max | Typically 1 mA |
| Analog Negative Supply ( $\mathrm{AI}_{\text {Ss }}$ ) | 2.7 | 2.7 | mA max | Typically 2 mA |
| Digital Negative Supply ( $\mathrm{DI}_{\text {ss }}$ ) | 0.1 | 0.1 | mA max | Typically 0.03 mA |
| Power Supply Rejection ${ }^{9}$ |  |  |  |  |
| Positive Supplies | 70 | 70 | dB typ | , |
| Negative Supplies | 75 | 75 | dB typ |  |
| Power Dissipation |  |  |  |  |
| Normal Operation | 40 | 40 | mW max | $\begin{aligned} & \overline{\text { SLEEP }=\text { Logic } 1,} \\ & \text { Typically } 25 \mathrm{~mW} \end{aligned}$ |
| Standby Operation ${ }^{10}$ | 20 (40 S Version) | 20 (40 T Version) | $\mu \mathrm{W}$ max | $\begin{aligned} & \text { SLEEP }=\text { Logic } 0, \\ & \text { Typically } 10 \mu \mathrm{~W} \end{aligned}$ |

## NOTES

${ }^{1}$ The $\mathrm{A}_{\text {IN }}$ pin presents a very high impedance dynamic load which varies with clock frequency.
${ }^{2}$ Temperature ranges are as follows: A, B Versions; $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; S, T Versions; $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
${ }^{3}$ Apply after calibration at the temperature of interest. Full-scale error applies for both unipolar and bipolar input ranges.
${ }^{4}$ Total drift over the specified temperature range since calibration at power-up at $+25^{\circ} \mathrm{C}$. This is guaranteed by design and/or characterization. Recalibration at any temperature will remove these errors.
${ }^{5}$ In unipolar mode the offset can have a negative value ( $-\mathrm{V}_{\mathrm{REF}}$ ) such that the unipolar mode can mimic bipolar mode operation.
${ }^{6}$ The specifications for input overrange and for input span apply additional constraints on the offset calibration range.
${ }^{7}$ For unipolar mode, input span is the difference between full-scale and zero scale. Fir bipolar mode, input span is the difference between positive and negative full-scale points. When using less than the maximum input span, the span range may be placed anywhere within the range of $\pm\left(\mathrm{V}_{\mathrm{REF}}+0.1\right)$.
${ }^{8}$ All digital outputs unloaded. All digital inputs at 5 V CMOS levels.
${ }^{9}$ Applies in 0.1 Hz to 10 Hz bandwidth. PSRR at 60 Hz will exceed 120 dB due to the digital filter.
${ }^{10} \mathrm{CLKIN}$ is stopped. All digital inputs are grounded.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)
$\mathrm{DV}_{\mathrm{DD}}$ to AGND . . . . . . . . . . . . . . . . . . -0.3 V to +6 V
$\mathrm{DV}_{\mathrm{DD}}$ to $\mathrm{AV}_{\mathrm{DD}} . . . . . . . . . . . . . . . . .-0.3 \mathrm{~V}$ to +0.3 V
$\mathrm{DV}_{\text {ss }}$ to AGND . . . . . . . . . . . . . . . . . . . . +0.3 V to -6 V
$A V_{D D}$ to AGND . . . . . . . . . . . . . . . . . -0.3 V to +6 V
$\mathrm{AV}_{\text {ss }}$ to AGND . . . . . . . . . . . . . . . . . . . . +0.3 V to -6 V
AGND to DGND . . . . . . . . . . . . . . . . . -0.3 V to +0.3 V
Digital Input Voltage to DGND . . . -0.3 V to $\mathrm{DV}_{\mathrm{DD}}+0.3 \mathrm{~V}$ Analog Input

Voltage to AGND . . . . . . AV $\mathrm{AV}_{\mathrm{Ss}}-0.3 \mathrm{~V}$ to $\mathrm{AV}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Input Current to Any Pin Except Supplies ${ }^{2}$. . . . . . $\pm 10 \mathrm{~mA}$
Operating Temperature Range
Commercial Plastic (A, B Versions) . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$

Industrial Cerdip (A, B Versions) . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Extended Cerdip (S, T Versions) . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 secs) . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Power Dissipation (Any Package) to $+75^{\circ} \mathrm{C}$. . . . . . 450 mW
Derates above $+75^{\circ} \mathrm{C}$ by . . . . . . . . . . . . . . . . . . $10 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$
NOTES
${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. ${ }^{2}$ Transient currents of up to 100 mA will not cause SCR latch-up.

## CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are removed.


## PIN FUNCTION DESCRIPTION

| Pin | Mnemonic | Description |
| :---: | :---: | :---: |
| 1 | MODE | Selects the Serial Interface Mode. If MODE is tied to -5 V , the AD7701 will operate in the asynchronous communications (AC) mode. The SCLK pin is configured as an input, and data is transmitted in two bytes, each with one start bit and two stop bits. If MODE is tied to DGND, the synchronous external clocking (SEC) mode is selected. SCLK is configured as an input, and the output appears without formatting, the MSB coming first. If MODE is tied to +5 V , the AD7701 operates in the synchronous self-clocking (SSC) mode. SCLK is configured as an output, with a clock frequency of $\mathrm{f}_{\mathrm{CLKIN}} / 4$ and $25 \%$ duty-cycle. |
| 2 | CLKOUT | Clock Output to generate an Internal Master Clock by connecting a crystal between CLKOUT and CLKIN. If an external clock is used, CLKOUT is not connected. |
| 3 | CLKIN | Clock Input for External Clock. |
| 4,17 | SC1, SC2 | System Calibration Pins. The state of these pins, when CAL is taken high, determines the type of calibration performed. |
| 5 | DGND | Digital Ground. Ground reference for all digital signals. |
| 6 | $\mathrm{DV}_{\text {ss }}$ | Digital Negative Supply, -5 V nominal. |
| 7 | $\mathrm{AV}_{\text {ss }}$ | Analog Negative Supply, -5 V nominal. |
| 8 | AGND | Analog Ground. Ground reference for all analog signals. |
| 9 | $\mathrm{A}_{\text {IN }}$ | Analog Input. |
| 10 | $\mathrm{V}_{\text {REF }}$ | Voltage Reference Input, +2.5 V nominal. This determines the value of positive full-scale in the unipolar mode and of both positive and negative full-scale in the bipolar mode. |
| 11 | $\overline{\text { SLEEP }}$ | Sleep mode pin. When this pin is taken low, the AD7701 goes into a low-power mode with typically $10 \mu \mathrm{~W}$ power consumption. |
| 12 | $\mathrm{BP} / \overline{\mathrm{UP}}$ | Bipolar/Unipolar Mode Pin. When this pin is low, the AD7701 is configured for a unipolar input range going from AGND to $\mathrm{V}_{\mathrm{REF}}$. When Pin 12 is high, the AD7701 is configured for a bipolar input range, $\pm \mathrm{V}_{\mathrm{REF}}$ - |
| 13 | CAL | Calibration Mode Pin. When CAL is taken high for more than 4 cycles, the AD7701 is reset and performs a calibration cycle when CAL is brought low again. The CAL pin can also be used as a strobe to synchronize the operation of several AD7701s. |
| 14 | $\mathrm{AV}_{\text {DD }}$ | Analog Positive Supply, +5 V nominal. |
| 15 | DV ${ }_{\text {DD }}$ | Digital Positive Supply, +5 V nominal. |
| 16 | $\overline{\mathrm{CS}}$ | Chip Select Input. When $\overline{\mathrm{CS}}$ is brought low, the AD7701 will begin to transmit serial data in a format determined by the state of the MODE pin. |
| 18 | $\overline{\text { DRDY }}$ | Data Ready output. $\overline{\mathrm{DRDY}}$ is low when valid data is available in the output register. It goes high after transmission of a word is completed. It also goes high for four clock cycles when a new data word is being loaded into the output register, to indicate that valid data is not available, irrespective of whether data transmission is complete or not. |
| 19 | SCLK | Serial Clock Input/Output. The SCLK pin in configured as an input or output, dependent on the type of serial data transmission that has been selected by the MODE pin. When configured as an output in the synchronous self-clocking mode, it has a frequency of $\mathrm{f}_{\text {CLKIN }} / 4$ and a duty cycle of $25 \%$. |
| 20 | SDATA | Serial Data Output. The AD7701's output data is available at this pin as a 16 -bit serial word. The transmission format is determined by the state of the MODE pin. |

PIN CONFIGURATION


ORDERING GUIDE

| Model $^{1}$ | Temperature <br> Range | Linearity <br> Error (\%FSR) | Package <br> Options |
| :--- | :--- | :--- | :--- |
| AD7701AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 0.003 | $\mathrm{~N}-20$ |
| AD7701BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 0.0015 | $\mathrm{~N}-20$ |
| AD7701AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 0.003 | $\mathrm{R}-20$ |
| AD7701BR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 0.0015 | $\mathrm{R}-20$ |
| AD7701AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 0.003 | $\mathrm{Q}-20$ |
| AD7701BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 0.0015 | $\mathrm{Q}-20$ |
| AD7701SQ ${ }^{3}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 0.003 | $\mathrm{Q}-20$ |
| AD7701TQ $^{3}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 0.0015 | $\mathrm{Q}-20$ |

[^27]| Parameter | Limit at $\mathbf{T}_{\text {min }}, \mathbf{T}_{\text {max }}$ (A, B Versions) | Limit at $\mathrm{T}_{\text {min }}, \mathrm{T}_{\text {max }}$ (S, T Versions) | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: |
| ${\overline{\mathrm{f}} \mathrm{CLKIN}^{3,4}}$ | 40 5 40 5 | $\begin{aligned} & 40 \\ & 5 \\ & 40 \\ & 5 \end{aligned}$ | kHz min MHz max kHz min MHz max | Master Clock Frequency: Internal Gate Oscillator Typically 4.096 MHz Master Clock Frequency: Externally Supplied |
| $\mathrm{tr}_{\mathrm{r}}{ }^{\text {S }}$ | 50 | 50 | ns max | Digital Output Rise Time. Typically 20 ns |
| $\mathrm{t}_{\mathrm{f}}{ }^{\text {s }}$ | 50 | 50 | ns max | Digital Output Fall Time. Typically 20 ns |
| $\mathrm{t}_{1}$ | 0 | 0 | ns min | SC1, SC2 to CAL High Setup Time |
|  | 50 | 50 | ns min | SC1, SC2 Hold Time After CAL Goes High |
| $\mathrm{t}_{3}{ }^{6}$ | 1000 | 1000 | ns min | SLEEP High to CLKIN High Setup Time |
| SSC Mode |  |  |  |  |
| $\mathrm{t}_{4}{ }^{\text {a }}$ | 3/f ${ }_{\text {CLKIN }}$ | 3/f ${ }_{\text {CLKIN }}$ | ns min | Data Access Time ( $\overline{\mathrm{CS}}$ Low to Data Valid) |
| $\mathrm{t}_{5}$ | 100 | 100 | ns max | SCLK Falling Edge to Data Valid Delay (25 ns typ) |
| $t_{6}$ | 250 | 250 | ns min | MSB Data Setup Time. Typically 380 ns |
| $\mathrm{t}_{7}$ | 300 | 300 | ns max | SCLK High Pulse Width. Typically 240 ns |
| $\mathrm{t}_{8}$ | 790 | 790 | ns max | SCLK Low Pulse Width. Typically 730 ns |
| $\begin{aligned} & \mathrm{t}_{\mathrm{t}^{8}}^{8} \\ & \mathrm{t}_{10} \end{aligned}$ | $\begin{aligned} & 1 / \mathrm{f}_{\text {CLKIN }}+200 \\ & \left(4 / \mathrm{f}_{\mathrm{CLKIN}}\right)+200 \end{aligned}$ | $\begin{aligned} & 1 / \mathrm{f}_{\text {CLKIN }}+200 \\ & \left(4 / \mathrm{f}_{\mathrm{CLKIN}}\right)+200 \end{aligned}$ | ns max ns max | SCLK Rising Edge to Hi-Z Delay ( $1 / \mathrm{f}_{\text {CLKIN }}+100 \mathrm{~ns}$ typ) $\overline{\mathrm{CS}}$ High to Hi-Z Delay |
|  |  |  |  |  |
| $\mathrm{f}_{\text {SCLK }}$ | 5 | 5 | MHz | Serial Clock Input Frequency |
| $\mathrm{t}_{11}$ | 50 | 50 | ns min | SCLK Input High Pulse Width |
| $\mathrm{t}_{12}$ | 180 | 180 | ns min | SCLK Low Pulse Width |
| $\mathrm{t}_{13}{ }^{7}$, 10 | 160 | 160 | ns max | Data Access Time ( $\overline{\mathrm{CS}}$ Low to Data Valid). Typically 80 ns |
| $\mathrm{t}_{14}{ }^{11}$ | 150 | 150 | ns min | SCLK Falling Edge to Data Valid Delay. Typically 75 ns |
| $\mathrm{t}_{15}{ }_{8}^{8}$ | 250 | 250 | ns min | $\overline{\mathrm{CS}}$ High to Hi-Z Delay |
| $\mathrm{t}_{16}{ }^{8}$ | 200 | 200 | ns min | SCLK Falling Edge to Hi-Z Delay. Typically 100 ns |
| AC Mode |  |  |  |  |
| $\mathrm{t}_{17}$ | 40 | 40 | ns max | $\overline{\mathrm{CS}}$ Setup Time. Typically 20 ns |
| $\mathrm{t}_{18}$ | 180 | 180 | ns max | Data Delay Time. Typically 90 ns |
| $\mathrm{t}_{19}$ | 200 | 200 | ns max | SCLK Falling Edge to Hi-Z Delay. Typically 100 ns |

NOTES
${ }^{1}$ Sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance. All input signals are specified with $\mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of 5 V$)$ and timed from a voltage level of 1.6 V . ${ }^{2}$ See Figures 1 to 5 .
${ }^{3}$ CLKIN Duty Cycle range is $20 \%$ to $80 \%$. CLKIN must be supplied whenever the AD7701 is not in SLEEP mode. If no clock is present in this case, the device can draw higher current than specified and possibly become uncalibrated.
${ }^{4}$ The AD7701 is production tested with $\mathrm{f}_{\text {CLKIN }}$ at 4.096 MHz . It is guaranteed by characterization to operate at 200 kHz .
${ }^{5}$ Specified using $10 \%$ and $90 \%$ points on waveform of interest.
${ }^{6}$ In order to synchronize several AD7701s together using the SLEEP pin, this specification is met.
${ }^{7} t_{4}$ and $t_{13}$ are measured with the load circuit of Figure 1 and defined as the time required for an output to cross 0.8 V or 2.4 V .
${ }^{8} t_{8}, t_{10}, t_{15}$ and $t_{16}$ are derived from the measured time taken by the data outputs to change 0.5 V when loaded with the circuit of Figure 1 . The measured number is then extrapolated back to remove the effects of charging or discharging the 100 pF capacitor. This means that the time quoted in the Timing Characteristics is the true bus relinquish time of the part and as such as independent of external bus loading capacitance.
${ }^{9}$ If $\overline{\mathrm{CS}}$ is returned high before all 16 bits are output, the SDATA and SCLK outputs will complete the current data bit and then go to high impedance.
${ }^{10}$ If $\overline{\mathrm{CS}}$ is activated asynchronously to $\overline{\mathrm{DRDY}}, \overline{\mathrm{CS}}$ will not be recognized if it occurs when $\overline{\mathrm{DRDY}}$ is high for four clock cycles. The propagation delay time may be as great as 4 CLKIN cycles plus 160 ns . To guarantee proper clocking of SDATA when using asynchronous $\overline{\mathrm{CS}}$, the SCLK input should not be taken high sooner then 4 CLKIN cycles plus 160 ns after $\overline{\mathrm{CS}}$ goes low.
${ }^{11}$ SDATA is clocked out on the falling edge of the SCLK input.


Figure 1. Load Circuit for Access Time and Bus Relinquish Time



2a. Calibration Control Timing


Figure 4a. SEC Mode Data Hold Time



Figure 4b. SEC Mode Timing Diagram

Figure 3. SSC Mode Data Hold Time


Figure 6. AC Mode Timing Diagram

## TERMINOLOGY

## LINEARITY ERROR

This is the maximum deviation of any code from a straight line passing through the endpoints of the transfer function. The endpoints of the transfer function are Zero-Scale (not to be confused with Bipolar Zero), a point 0.5 LSB below the first code transition ( $000 \ldots 000$ to $000 \ldots 001$ ) and Full-Scale, a point 1.5 LSB above the last code transition (111 . . . 110 to 111 . . 111). The error is expressed as a percentage of full scale.

## DIFFERENTIAL LINEARITY ERROR

This is the difference between any code's actual width and the ideal (1 LSB) width. Differential Linearity Error is expressed in LSBs. A differential linearity specification of $\pm 1$ LSB or less guarantees monotonicity.

## POSITIVE FULL-SCALE ERROR

Positive Full-Scale Error is the deviation of the last code transition (111 . . . 110 to 111 . . . 111) from the ideal ( $\mathrm{V}_{\mathrm{REF}}-3 / 2$ LSBs). It applies to both positive and negative analog input ranges and it is expressed in microvolts.

## UNIPOLAR OFFSET ERROR

Unipolar Offset Error is the deviation of the first code transition from the ideal (AGND + 0.5 LSB) when operating in the unipolar mode. It is expressed in microvolts.

## BIPOLAR ZERO ERROR

This is the deviation of the mid-scale transition (0111 . . . 111 to 1000 . . 000) from the ideal (AGND - 0.5 LSB ) when operating in the bipolar mode. It is expressed in microvolts.

## BIPOLAR NEGATIVE FULL-SCALE ERROR

This is the deviation of the first code transition from the ideal ( $-\mathrm{V}_{\text {REF }}+0.5 \mathrm{LSB}$ ), when operating in the bipolar mode. It is expressed in microvolts.

## POSITIVE FULL-SCALE OVERRANGE

Positive Full-Scale Overrange is the amount of overhead available to handle input voltages greater than $+\mathrm{V}_{\text {REF }}$ (for example, noise peaks or excess voltages due to system gain errors in system calibration routines) without introducing errors due to overloading the analog modulator or overflowing the digital filter. It is expressed in millivolts.

## NEGATIVE FULL-SCALE OVERRANGE

This is the amount of overhead available to handle voltages below - $\mathrm{V}_{\text {REF }}$ without overloading the analog modulator or overflowing the digital filter. Note that the analog input will accept negative voltage peaks even in the unipolar mode. The overhead is expressed in millivolts.

## FEATURES

Monolithic 20-Bit ADC
0.0003\% Linearity Error

20-Bit No Missed Codes
On-Chip Self-Calibration Circuitry
Programmable Low-Pass Filter 0.1 Hz to 10 Hz Corner Frequency

0 to +2.5 V or $\pm 2.5 \mathrm{~V}$ Analog Input Range
4 kSPS Output Data Rate
Flexible Serial Interface
Ultralow Power

## APPLICATIONS

Industrial Process Control
Weigh Scales
Portable Instrumentation
Remote Data Acquisition

## GENERAL DESCRIPTION

The AD7703 is a 20 -bit ADC which uses a sigma delta conversion technique. The analog input is continuously sampled by an analog modulator whose mean output duty cycle is proportional to the input signal. The modulator output is processed by an on-chip digital filter with a six-pole Gaussian response, which updates the output data register with 20 -bit binary words at word rates up to 4 kHz . The sampling rate, filter corner frequency and output word rate are set by a master clock input that may be supplied externally, or by an on-chip gate oscillator.
The inherent linearity of the ADC is excellent, and endpoint accuracy is ensured by self-calibration of zero and full scale which may be initiated at any time. The self-calibration scheme can also be extended to null system offset and gain errors in the input channel.
The output data is accessed through a serial port, which has two synchronous modes suitable for interfacing to shift registers or the serial ports of industry standard microcontrollers.

CMOS construction ensures low power dissipation, and a power down mode reduces the idle power consumption to only $10 \mu \mathrm{~W}$.

## FUNCTIONAL BLOCK DIAGRAM



## PRODUCT HIGHLIGHTS

1. The AD7703 offers 20-bit resolution coupled with outstanding $0.0003 \%$ accuracy.
2. No missing codes ensures true, usable, 20-bit dynamic range, removing the need for programmable gain and level-setting circuitry.
3. The effects of temperature drift are eliminated by on-chip self-calibration, which removes zero and gain error. External circuits can also be included in the calibration loop to remove system offsets and gain errors.
4. A flexible synchronization allows the AD7703 to interface directly to the serial ports of industry standard microcontrollers and DSP processors.
5. Low operating power consumption and an ultralow power standby mode make the AD7703 ideal for loop powered remote sensing applications, or battery-powered portable instruments.

| Parameter | A/S Versions ${ }^{2}$ | B Version ${ }^{2}$ | C Version ${ }^{2}$ | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| STATIC PERFORMANCE <br> Resolution <br> Integral Nonlinearity, $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ $+25^{\circ} \mathrm{C}$ $T_{\min } \text { to } T_{\max }$ <br> Differential Nonlinearity, $T_{\text {min }}$ to $T_{\text {max }}$ <br> Positive Full-Scale Error ${ }^{3}$ <br> Full-Scale Drift ${ }^{4}$ <br> Unipolar Offset Error ${ }^{3}$ <br> Unipolar Offset Drift ${ }^{4}$ <br> Bipolar Zero Error ${ }^{3}$ <br> Bipolar Zero Drift ${ }^{4}$ <br> Bipolar Negative Full-Scale Error ${ }^{3}$ <br> Bipolar Negative Full-Scale Drift ${ }^{4}$ <br> Noise (Referred to Output) | $\begin{aligned} & 20 \\ & \pm 0.0015 \\ & \pm 0.003 \\ & \pm 0.003 \\ & \pm 0.5 \\ & \pm 4 \\ & \pm 16 \\ & \pm 19 / \pm 37 \\ & \pm 4 \\ & \pm 16 \\ & \pm 26 \\ & \pm 67 \quad+48 /-400 \\ & \pm 4 \\ & \pm 16 \\ & \pm 13 \\ & \pm 34 \quad+24 /-200 \\ & \pm 8 \\ & \pm 32 \\ & \pm 10 / \pm 20 \\ & 1.6 \end{aligned}$ | $\begin{aligned} & 20 \\ & \pm 0.0007 \\ & \pm 0.0015 \\ & \pm 0.0015 \\ & \pm 0.5 \\ & \pm 4 \\ & \pm 16 \\ & \pm 19 \\ & \pm 4 \\ & \pm 16 \\ & \pm 26 \\ & \pm 67 \\ & \pm 4 \\ & \pm 16 \\ & \pm 13 \\ & \pm 34 \\ & \pm 8 \\ & \pm 32 \\ & \pm 10 \\ & 1.6 \end{aligned}$ | $\begin{aligned} & 20 \\ & \pm 0.0003 \\ & \pm 0.0008 \\ & \pm 0.0012 \\ & \pm 0.5 \\ & \pm 4 \\ & \pm 16 \\ & \pm 19 \\ & \pm 4 \\ & \pm 16 \\ & \pm 26 \\ & \pm 67 \\ & \pm 4 \\ & \pm 16 \\ & \pm 13 \\ & \pm 34 \\ & \pm 8 \\ & \pm 32 \\ & \pm 10 \\ & 1.6 \end{aligned}$ | Bits <br> \% FSR typ <br> \% FSR max <br> \% FSR max <br> LSB typ <br> LSB typ <br> LSB max <br> LSB typ <br> LSB typ <br> LSB max <br> LSB typ <br> LSB typ <br> LSB typ <br> LSB max <br> LSB typ <br> LSB typ <br> LSB typ <br> LSB max <br> LSB typ <br> LSB rms typ | Guaranteed No Missing Codes <br> Temp Range: 0 to $+70^{\circ} \mathrm{C}$ Specified Temp Range <br> Temp Range: 0 to $+70^{\circ} \mathrm{C}$ Specified Temp Range |
| DYNAMIC PERFORMANCE <br> Sampling Frequency, $\mathrm{f}_{\mathrm{S}}$ Output Update Rate, $\mathrm{f}_{\text {OUT }}$ Filter Corner Frequency, $\mathrm{f}_{-3 \mathrm{~dB}}$ Settling Time to $\pm 0.0007 \%$ FS | $\mathrm{f}_{\text {CLKIN }} / 256$ <br> $\mathrm{f}_{\text {CLKIN }} / 1024$ <br> $\mathrm{f}_{\text {CLKIN }} / 409,600$ <br> $507904 / \mathrm{f}_{\text {CLKIN }}$ | $\mathrm{f}_{\text {CLKIN }} / 256$ <br> $\mathrm{f}_{\text {CLKIN }} / 1024$ <br> $\mathrm{f}_{\text {CLKIN }} / 409,600$ <br> $507904 / \mathrm{f}_{\text {CLKIN }}$ | $\mathrm{f}_{\text {CLKIN }} / 256$ <br> $\mathrm{f}_{\text {CLKIN }} / 1024$ <br> $\mathrm{f}_{\text {CLKIN }} / 409,600$ <br> $507904 / \mathrm{f}_{\text {CLKIN }}$ | Hz <br> Hz <br> Hz <br> sec | For Full-Scale Input Step |
| SYSTEM CALIBRATION <br> Positive Full-Scale Calibration Range <br> Positive Full-Scale Overrange <br> Negative Full-Scale Overrange <br> Maximum Offset Calibration Range ${ }^{5,6}$ <br> Unipolar Input Range <br> Bipolar Input Range <br> Input Span ${ }^{7}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{REF}}+0.1 \\ & \mathrm{~V}_{\mathrm{REF}}+0.1 \\ & -\left(\mathrm{V}_{\mathrm{REF}}+0.1\right) \\ & \\ & -\left(\mathrm{V}_{\mathrm{REF}}+0.1\right) \\ & 0.4 \mathrm{~V}_{\mathrm{REF}} \text { to }+0.4 \mathrm{~V}_{\mathrm{REF}} \\ & 0.8 \mathrm{~V}_{\mathrm{REF}} \\ & 2 \mathrm{~V}_{\mathrm{REF}}+0.2 \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{REF}}+0.1 \\ & \mathrm{~V}_{\mathrm{REF}}+0.1 \\ & -\left(\mathrm{V}_{\mathrm{REF}}+0.1\right) \\ & -\left(\mathrm{V}_{\mathrm{REF}}+0.1\right) \\ & -0.4 \mathrm{~V}_{\mathrm{REF}} \text { to }+0.4 \mathrm{~V}_{\mathrm{REF}} \\ & 0.8 \mathrm{~V}_{\mathrm{REF}} \\ & 2 \mathrm{~V}_{\mathrm{REF}}+0.2 \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{REF}}+0.1 \\ & \mathrm{~V}_{\mathrm{REF}}+0.1 \\ & -\left(\mathrm{V}_{\mathrm{REF}}-+0.1\right) \\ & -\left(\mathrm{V}_{\mathrm{REF}}+0.1\right) \\ & -0.4 \mathrm{~V}_{\mathrm{REF}} \text { to }+0.4 \mathrm{~V}_{\mathrm{REF}} \\ & 0.8 \mathrm{~V}_{\mathrm{REF}} \\ & 2 \mathrm{~V}_{\mathrm{REF}}+0.2 \end{aligned}$ | V max <br> V max <br> V max <br> $V$ max <br> $V$ max <br> V min <br> V max | System Calibration Applies to Unipolar and Bipolar Ranges. After Calibration, if $A_{\text {IN }}>V_{\text {REF }}$, the Device Will Output All 1s. If $\mathrm{A}_{\mathrm{IN}}<0$ (Unipolar) or $-\mathrm{V}_{\mathrm{REF}}$ (Bipolar), the Device Will Output all 0 s. |
| ANALOG INPUT <br> Unipolar Input Range Bipolar Input Range Input Capacitance Input Bias Current ${ }^{1}$ | $\begin{aligned} & 0 \text { to }+2.5 \\ & \pm 2.5 \\ & 20 \\ & 1 \end{aligned}$ | $\begin{aligned} & 0 \text { to }+2.5 \\ & \pm 2.5 \\ & 20 \\ & 1 \end{aligned}$ | $\begin{aligned} & 0 \text { to }+2.5 \\ & \pm 2.5 \\ & 20 \\ & 1 \end{aligned}$ | Volts <br> Volts <br> pF typ <br> nA typ |  |
| LOGIC INPUTS <br> All Inputs except CLKIN <br> $\mathrm{V}_{\text {INL }}$, Input Low Voltage <br> $\mathrm{V}_{\text {INH }}$, Input High Voltage <br> CLKIN <br> $\mathrm{V}_{\text {INL }}$, Input Low Voltage <br> $\mathrm{V}_{\text {INH }}$, Input High Voltage <br> $\mathrm{I}_{\mathrm{IN}}$, Input Current | $\begin{aligned} & 0.8 \\ & 2.0 \\ & \\ & 0.8 \\ & 3.5 \\ & 10 \end{aligned}$ | $\begin{aligned} & 0.8 \\ & 2.0 \\ & \\ & 0.8 \\ & 3.5 \\ & 10 \end{aligned}$ | $\begin{aligned} & 0.8 \\ & 2.0 \\ & \\ & 0.8 \\ & 3.5 \\ & 10 \end{aligned}$ | V max <br> $V$ min <br> V max <br> V min <br> $\mu \mathrm{A}$ max |  |
| LOGIC OUTPUTS <br> $\mathrm{V}_{\mathrm{OL}}$, Output Low Voltage <br> $\mathrm{V}_{\mathrm{OH}}$, Output High Voltage <br> Floating State Leakage Current <br> Floating State Output Capacitance | $\begin{aligned} & 0.4 \\ & \mathrm{DV}_{\mathrm{DD}}-1 . \\ & \pm 10 \\ & 9 \end{aligned}$ | $\begin{aligned} & 0.4 \\ & \mathrm{DV}_{\mathrm{DD}^{-1}} \\ & \pm 10 \\ & 9 \end{aligned}$ | $\begin{aligned} & 0.4 \\ & \mathrm{DV}_{\mathrm{DD}}-1 \\ & \pm 10 \\ & 9 \end{aligned}$ | V max <br> V min <br> $\mu \mathrm{A}$ max pF typ | $\begin{aligned} & \mathrm{I}_{\text {SINK }}=1.6 \mathrm{~mA} \\ & \mathrm{I}_{\text {SOURCE }}=100 \mu \mathrm{~A} \end{aligned}$ |
| POWER REQUIREMENTS ${ }^{8}$ <br> Power Supply Voltages <br> Analog Positive Supply ( $\mathrm{AV} \mathrm{VD}_{\mathrm{DD}}$ ) <br> Digital Positive Supply ( $\mathrm{DV}_{\mathrm{DD}}$ ) <br> Analog Negative Supply ( $\mathrm{AV}_{\mathrm{SS}}$ ) <br> Digital Negative Supply ( $\mathrm{DV}_{\mathrm{SS}}$ ) <br> Calibration Memory Retention <br> Power Supply Voltage | $\begin{aligned} & 4.5 / 5.5 \\ & 4.5 / \mathrm{AV} \\ & -4.5 /-5.5 \\ & -4.5 /-5.5 \\ & \\ & 2.0 \end{aligned}$ | $\begin{aligned} & 4.5 / 5.5 \\ & 4.5 / \mathrm{AV} \\ & -4.5 /-5.5 \\ & -4.5 /-5.5 \\ & \\ & 2.0 \end{aligned}$ | $\begin{aligned} & 4.5 / 5.5 \\ & 4.5 / \mathrm{AV} \\ & -4.5 /-5.5 \\ & -4.5 /-5.5 \\ & \\ & 2.0 \end{aligned}$ | $\mathrm{V} \min / \mathrm{V}$ max <br> $V \min / V \max$ <br> $\mathrm{V} \min / V_{\max }$ <br> $\mathrm{V} \min / \mathrm{V}$ max <br> V min | For Specified Performance |


| Parameter | A/S Versions ${ }^{2}$ | B Version ${ }^{2}$ | C Version ${ }^{2}$ | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| STATIC PERFORMANCE |  |  |  |  |  |
| DC Power Supply Currents* |  |  |  |  |  |
| Analog Positive Supply ( $\mathrm{AI}_{101}$ ) | 3.2 | 3.2 | 3.2 | $m A \max$ | Typically 2 mA |
| Digital Positive Supply ( $\mathrm{DI}_{\mathrm{LD}}$ ) | 1.5 | 1.5 | 1.5 | $m A \max$ | Typically 1 mA |
| Analog Negative Supply ( $\mathrm{AI}_{\mathrm{ss}}$ ) | 3.2 | 3.2 | 3.2 | mA max | Typically 2 mA |
| Digital Negative Supply ( $\mathrm{DI}_{\text {ss }}$ ) | 0.1 | 0.1 | 0.1 | $m \mathrm{~m}$ max | Typically 0.03 mA |
| Power Supply Rejection ${ }^{4}$ ( ${ }^{\text {P }}$ |  |  |  |  |  |
| Positive Supplies | 70 | 70 | 70 | dB typ |  |
| Negative Supplies | 75 | 75 | 75 | dB typ |  |
| Power Dissipation |  |  |  |  |  |
| Normal Operation | 40 | 40 | 40 | mW max | $\begin{aligned} & \overline{\text { SLEEP }}=\text { Logic } 1, \\ & \text { Typically } 25 \mathrm{~mW} \end{aligned}$ |
| Standby Operation ${ }^{10}$ |  |  |  |  | $\overline{\text { SLEEP }}=$ Logic 0 |
| A, B, C | 20 | 20 | 20 | $\mu \mathrm{W}$ max | Typically $10 \mu \mathrm{~W}$ |
| S | 40 | 40 | 40 | $\mu \mathrm{W}$ max |  |

NOTES
${ }^{1}$ The $A_{\text {IN }}$ pin presents a very high impedance dynamic load which varies with clock frequency. A ceramic 1 nF capacitor from the $\mathrm{A}_{\mathrm{IN}}$ to AGND is necessary. Source resistance should be $750 \Omega$ or less.
${ }^{2}$ Temperature Ranges are as follows: A, B, C Versions: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; S Version: $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
${ }^{3}$ Applies after calibration at the temperature of interest. Full-Scale Error applies for both unipolar and bipolar input ranges.
${ }^{4}$ Total drift over the specified temperature range after calibration at power-up at $+25^{\circ} \mathrm{C}$. This is guaranteed by design and/or characterization. Recalibration at any temperature will remove these errors.
${ }^{\text {S }}$ In unipolar mode the offset can have a negative value ( $-\mathrm{V}_{\mathrm{REF}}$ ) such that the unipolar mode can mimic bipolar mode operation.
${ }^{6}$ The specifications for input overrange and for input span apply additional constraints on the offset calibration range.
${ }^{7}$ For unipolar mode, input span is the difference between full scale and zero scale. For bipolar mode, input span is the difference between positive and negative full-scale points. When using less than the maximum input span, the span range may be placed anywhere within the range of $\pm\left(\mathrm{V}_{\mathrm{REF}}+0.1\right)$.
${ }^{8}$ All digital outputs unloaded. All digital inputs at 5 V CMOS levels.
${ }^{9}$ Applies in 0.1 Hz to 10 Hz bandwidth. PSRR at 60 Hz will exceed 120 dB due to the digital filter.
${ }^{10}$ CLKIN is stopped. All digital inputs are grounded.
Specifications subject to change without notice.

ABSOLUTE MAXIMUM RATINGS*
( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)
$\mathrm{DV}_{\mathrm{DD}}$ to AGND . . . . . . . . . . . . . . . . . . -0.3 V to +6 V
$\mathrm{DV}_{\mathrm{DD}}$ to $\mathrm{AV}_{\mathrm{DD}}$. . . . . . . . . . . . . . . . . -0.3 V to +0.3 V
$\mathrm{DV}_{\text {ss }}$ to AGND . . . . . . . . . . . . . . . . . . . . +0.3 V to -6 V
$\mathrm{AV}_{\mathrm{DD}}$ to AGND . . . . . . . . . . . . . . . . . . -0.3 V to +6 V
$\mathrm{AV}_{\mathrm{ss}}$ to AGND . . . . . . . . . . . . . . . . . . . . +0.3 V to -6 V
AGND to DGND . . . . . . . . . . . . . . . . . -0.3 V to +0.3 V
Digital Input Voltage to DGND . . -0.3 V to $\mathrm{DV}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Analog Input Voltage to AGND . . . . . . . . . AV $\mathrm{AV}_{\mathrm{ss}}-0.3 \mathrm{~V}$ to $\mathrm{AV}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Input Current to any Pin Except Supplies ${ }^{1}$. . . . . . . $\pm 10 \mathrm{~mA}$
Operating Temperature Range
Industrial (A, B, C Versions) . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Extended (S Version) . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 secs) . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Power Dissipation (DIP Package) to $+75^{\circ} \mathrm{C}$. . . . . . 450 mW
Derates above $+75^{\circ} \mathrm{C}$ by . . . . . . . . . . . . . . . . . $10 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$
Power Dissipation (SOIC Package) to $+75^{\circ} \mathrm{C}$. . . . . . . 250 mW
Derates above $+75^{\circ} \mathrm{C}$ by . . . . . . . . . . . . . . . . $15 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$

## NOTES

*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{1}$ Transient currents of up to 100 mA will not cause SCR latch-up.

## ORDERING GUIDE

| Model | Temperature <br> Range | Linearity Error <br> (\% FSR) | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD7703AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 0.003 | $\mathrm{~N}-20$ |
| AD7703BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 0.0015 | $\mathrm{~N}-20$ |
| AD7703CN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 0.0012 | $\mathrm{~N}-20$ |
| AD7703AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 0.003 | $\mathrm{R}-20$ |
| AD7703BR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 0.0015 | $\mathrm{R}-20$ |
| AD7703CR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 0.0012 | $\mathrm{R}-20$ |
| AD7703AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 0.003 | $\mathrm{Q}-20$ |
| AD7703BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 0.0015 | $\mathrm{Q}-20$ |
| AD7703CQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 0.0012 | $\mathrm{Q}-20$ |
| AD7703SQ ${ }^{2}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 0.003 | $\mathrm{Q}-20$ |

## NOTES

${ }^{1} \mathrm{~N}=$ Plastic DIP; $\mathrm{R}=$ SOIC; $\mathrm{Q}=$ Cerdip. For outline information see Package Information section.
${ }^{2}$ Available to $/ 883$ B processing only. Contact local sales office for military data sheet.

## CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are removed.
 $=4.096 \mathrm{MHz}$; Input Levels: Logic $0=0 \mathrm{~V}$, Logic $1=\mathrm{DV}_{\mathrm{DD}}$; unless otherwise stated.)

| Parameter | Limit at $T_{\text {min }}, T_{\text {max }}$ (A, B, C Versions) | Limit at $\mathbf{T}_{\text {min }}, \mathbf{T}_{\text {max }}$ (S Version) | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: |
| $\overline{\mathrm{f}}$ CLKIN ${ }^{3,4}$ | 40 5 40 5 | $\begin{aligned} & 40 \\ & 5 \\ & 40 \\ & 5 \end{aligned}$ | $\mathrm{kHz} \min$ $\mathrm{MHz} \max$ kHz min MHz max | Master Clock Frequency: Internal Gate Oscillator Typically 4096 kHz Master Clock Frequency: Externally Supplied |
| $\mathrm{tr}_{\mathrm{r}_{5}}$ | 50 | 50 | ns max | Digital Output Rise Time. Typically 20 ns |
| $\mathrm{t}_{\mathrm{f}}{ }^{5}$ | 50 | 50 | ns max | Digital Output Fall Time. Typically 20 ns |
| $\mathrm{t}_{1}$ | 0 | 0 | ns min | SC1, SC2 to CAL High Setup Time |
|  | 50 | 50 | ns min | SC1, SC2 Hold Time After CAL Goes High |
| $\mathrm{t}_{3}{ }^{6}$ | 1000 | 1000 | ns min | SLEEP High to CLKIN High Setup Time |
| SSC MODE |  |  |  |  |
| $\mathrm{t}_{4}{ }^{\text {² }}$ | $3 / \mathrm{f}_{\text {CLKIN }}$ | $3 / \mathrm{f}_{\text {CLKIN }}$ | ns min | Data Access Time ( $\overline{\mathrm{CS}}$ Low to Data Valid) |
| $\mathrm{t}_{5}$ | 100 | 100 | ns max | SCLK Falling Edge to Data Valid Delay ( 25 ns typ) |
| $\mathrm{t}_{6}$ | 250 | 250 | ns min | MSB Data Setup Time. Typically 380 ns |
| $\mathrm{t}_{7}$ | 300 | 300 | ns max | SCLK High Pulse Width. Typically 240 ns |
| $\mathrm{t}_{8}$ | 790 | 790 | ns max | SCLK Low Pulse Width. Typically 730 ns |
| $\mathrm{t}_{9}$ | $1 / \mathrm{f}_{\text {CLKIN }}+200$ | $1 / \mathrm{f}_{\text {CLKIN }}+200$ | ns max | SCLK Rising Edge to Hi-Z Delay ( $1 / \mathrm{f}_{\text {CLKIN }}+100 \mathrm{~ns} \mathrm{typ}$ ) |
| $\mathrm{t}_{10} 8,9$ | $4 / \mathrm{f}_{\text {CLKIN }}+200$ | $4 / \mathrm{f}_{\text {CLKIN }}+200$ | ns max | $\overline{\mathrm{CS}}$ High to Hi-Z Delay |
| SEC MODE |  |  |  |  |
| $\mathrm{f}_{\text {SCLK }}$ | 5 | 5 | MHz max | Serial Clock Input Frequency |
| $\mathrm{t}_{11}$ | 50 | 50 | ns min | SCLK High Pulse Width |
| $\mathrm{t}_{12}$ | 180 | 180 | ns min | SCLK Low Pulse Width |
| $\mathrm{t}_{13}{ }^{7}{ }^{\text {a }} 10$ | 160 | 160 | ns max | Data Access Time ( $\overline{\mathrm{CS}}$ Low to Data Valid). Typically 80 ns |
| $\mathrm{t}_{14}{ }^{11}$ | 150 | 150 | ns min | SCLK Falling Edge to Data Valid Delay. Typically 75 ns |
| $\mathrm{t}_{15}{ }^{8}$ | 250 | 250 | ns $\min$ | $\overline{\mathrm{CS}}$ High to Hi-Z Delay |
| $\mathrm{t}_{16}{ }^{8}$ | 200 | 200 | ns min | SCLK Falling Edge to Hi-Z Delay. Typically 100 ns |

## NOTES

${ }^{1}$ Sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance. All input signals are specified with $\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of 5 V$)$ and timed from a voltage level of 1.6 V .
${ }^{2}$ See Figures 1 to 6.
${ }^{3}$ CLKIN duty cycle range is $20 \%$ to $80 \%$. CLKIN must be supplied whenever the AD7703 is not in SLEEP mode. If no clock is present in this case, the device can draw higher current than specified and possibly become uncalibrated.
${ }^{4}$ The AD7703 is production tested with $\mathrm{f}_{\mathrm{CLKIN}}$ at 4.096 MHz . It is guaranteed by characterization to operate at 200 kHz .
${ }^{5}$ Specified using $10 \%$ and $90 \%$ points on waveform of interest.
${ }^{6}$ In order to synchronize several AD7703s together using the $\overline{\text { SLEEP }}$ pin, this specification must be met.
${ }^{7} \mathrm{t}_{4}$ and $\mathrm{t}_{13}$ are measured with the load circuit of Figure 1 and defined as the time required for an output to cross 0.8 V or 2.4 V .
${ }^{8} t_{9}, t_{10}, t_{15}$ and $t_{16}$ are derived from the measured time taken by the data outputs to change 0.5 V when loaded with the circuit of Figure 1 . The measured number is then extrapolated back to remove the effects of charging or discharging the 100 pF capacitor. This means that the time quoted in the Timing Characteristics is the true bus relinquish time of the part and as such is independent of external bus loading capacitances.
${ }^{9}$ If $\overline{\mathrm{CS}}$ is returned high before all 20 bits are output, the SDATA and SCLK outputs will complete the current data bit and then go to high impedance.
${ }^{10}$ If $\overline{C S}$ is activated asynchronously to $\overline{D R D Y}, \overline{C S}$ will not be recognized if it occurs when $\overline{\text { DRDY }}$ is high for four clock cycles. The propagation delay time may be as great as 4 CLKIN cycles plus 160 ns . To guarantee proper clocking of SDATA when using asynchronous $\overline{\mathrm{CS}}$, The SCLK input should not be taken high sooner than 4 CLKIN cycles plus 160 ns after $\overline{\mathrm{CS}}$ goes low.
${ }^{11}$ SDATA is clocked out on the falling edge of the SCLK input.


Figure 1. Load Circuit for Access Time and Bus Relinquish Time


Figure 2. Calibration Control Timing


Figure 3. Sleep Mode Timing


Figure 4. SSC Mode Data Hold Time
Figure 5a. SEC Mode Data Hold Time


Figure 5b. SEC Mode Timing Diagram


Figure 6. SSC Mode Timing Diagram

## POSITIVE FULL-SCALE OVERRANGE

Positive full-scale overrange is the amount of overhead available to handle input voltages greater than $+\mathrm{V}_{\mathrm{REF}}$ (for example, noise peaks or excess voltages due to system gain errors in system calibration routines) without introducing errors due to overloading the analog modulator or overflowing the digital filter.

## NEGATIVE FULL-SCALE OVERRANGE

This is the amount of overhead available to handle voltages below $-\mathrm{V}_{\text {REF }}$ without overloading the analog modulator or overflowing the digital filter. Note that the analog input will accept negative voltage peaks even in the unipolar mode.

## OFFSET CALIBRATION RANGE

In the system calibration modes (SC2 Low) the AD7703 calibrates its offset with respect to the $\mathrm{A}_{\text {IN }}$ pin. The offset calibration range specification defines the range of voltages that the AD7701 can accept and still calibrate offset accurately.

## FULL-SCALE CALIBRATION RANGE

This is the range of voltages that the AD7703 can accept in the system calibration mode and still calibrate full scale correctly.

## INPUT SPAN

In system calibration schemes, two voltages applied in sequence to the AD7703's analog input define the analog input range. The input span specification defines the minimum and maximum input voltages from zero to full scale that the AD7703 can accept and still calibrate gain accurately.

## PIN FUNCTION DESCRIPTION

| Pin | Mnemonic | Description |
| :---: | :---: | :---: |
| 1 | MODE | Selects the Serial Interface Mode. If MODE is tied to DGND, the Synchronous External Clocking (SEC) mode is selected. SCLK is configured as an input, and the output appears without formatting, the MSB coming first. If MODE is tied to +5 V , the AD7703 operates in the Synchronous Self-Clocking (SSC) mode. SCLK is configured as an output, with a clock frequency of $\mathrm{f}_{\text {CLKIN }} / 4$ and $25 \%$ duty cycle. |
| 2 | CLKOUT | Clock Output to generate an Internal Master Clock by connecting a crystal between CLKOUT and CLKIN. If an external clock is used, CLKOUT is left open circuit. |
| 3 | CLKIN | Clock Input for External Clock. |
| 4, 17 | SC1, SC2 | System Calibration Pins. The state of these pins, when CAL is taken high, determines the type of calibration performed. |
| 5 | DGND | Digital Ground. Ground reference for all digital signals. |
| 6 | DV ${ }_{\text {ss }}$ | Digital Negative Supply, -5 V nominal. |
| 7 | $\mathrm{AV}_{\text {ss }}$ | Analog Negative Supply, -5 V nominal. |
| 8 | AGND | Analog Ground. Ground reference for all analog signals. |
| 9 | $\mathrm{A}_{\text {IN }}$ | Analog Input. |
| 10 | $\mathrm{V}_{\text {REF }}$ | Voltage Reference Input, +2.5 V nominal. This determines the value of positive full scale in the unipolar mode and of both positive and negative full-scale in the Bipolar Mode. |
| 11 | $\overline{\text { SLEEP }}$ | Sleep mode pin. When this pin is taken Low, the AD7703 goes into a low-power mode with typically $10 \mu \mathrm{~W}$ power consumption. |
| 12 | BP/ $/ \overline{\mathrm{UP}}$ | Bipolar/Unipolar mode pin. When this pin is low the AD7703 is configured for a unipolar input range of AGND to $\mathrm{V}_{\text {REF }}$. When Pin 12 is High, the AD7703 is configured for a bipolar input range, $\pm \mathrm{V}_{\mathrm{REF}}$ - |
| 13 | CAL | Calibration mode pin. When CAL is taken High for more than 4 master clock cycles, the AD7703 is reset and performs a calibration cycle when CAL is brought Low again. The CAL pin can also be used as a strobe to synchronize the operation of several AD7703s. |
| 14 | $\mathrm{AV}_{\text {DD }}$ | Analog Positive Supply, +5 V nominal. |
| 15 | DV ${ }_{\text {DD }}$ | Digital Positive Supply, +5 V nominal. |
| 16 | $\overline{\mathrm{CS}}$ | Chip Select Input. When $\overline{\mathrm{CS}}$ is brought low, the AD7703 will begin to transmit serial data in a format determined by the state of the MODE pin. |
| 18 | $\overline{\text { DRDY }}$ | Data Ready Output. $\overline{\text { DRDY }}$ is low when valid data is available in the output register. It goes High after transmission of a word is completed. It also goes High for four clock cycles when a new data word is being loaded into the output register, to indicate that valid data is not available, irrespective of whether data transmission is complete or not. |
| 19 | SCLK | Serial Clock Input/Output. The SCLK pin in configured as an input or output, dependent on the type of serial data transmission that has been selected by the MODE pin. When configured as an output in the Synchronous Self-Clocking mode, it has a frequency of $\mathrm{f}_{\text {CLKIN }} / 4$ and a duty cycle of $25 \%$. |
| 20 | SDATA | Serial Data Output. The AD7703's output data is available at this pin as a 20-bit serial word. | LC² $^{2}$ MOS

## FEATURES

Charge Balancing ADC
24 Bits No Missing Codes
$\pm \mathbf{0 . 0 0 1 5 \%}$ Nonlinearity
Two-Channel Programmable Gain Front End
Gains from 1 to 128
Differential Input for Low Level Channels High-Level Input on AD7712
Low-Pass Filter with Programmable Filter Cutoffs
Ability to Read/Write Calibration Coefficients Bidirectional Microcontroller Serial Interface Internal/External Reference Option
Single or Dual Supply Operation
Low Power ( 25 mW typ) with Power-Down Mode

## APPLICATIONS

Weigh Scales
Thermocouples
Process Control
Smart Transmitters
Portable Industrial Instruments

## GENERAL DESCRIPTION

The AD7710/AD7712 is a complete analog front end for low frequency measurement applications. The device has two analog input channels and accepts either low level signals directly from a transducer or high level ( $\pm 4 \times \mathrm{V}_{\text {REF }}$ for AD7712 AIN2) signals and outputs a serial digital word. It employs a sigma-delta conversion technique to realize up to 24 bits of no missing codes performance. The input signals are applied to a proprietary programmable gain front end based around an analog modulator. The modulator output is processed by an on-chip digital filter. The first notch of this digital filter can be programmed via the on-chip control register allowing adjustment of the filter cutoff and settling time.
Normally, one of the channels will be used as the main channel with the second channel used as an auxiliary input to periodically measure a second voltage. The part can be operated from a single supply (by tying the $\mathrm{V}_{\text {SS }}$ pin to AGND) provided that the input signals on the low level analog inputs are more positive than -30 mV . By taking the $\mathrm{V}_{\text {SS }}$ pin negative, the part can convert signals down to $-\mathrm{V}_{\text {REF }}$ on the low level inputs. The lowlevel inputs, as well as the reference input, features differential input capability.

The AD7710/AD7712 is ideal for use in smart, microcontrollerbased systems. Input channel selection, gain settings and signal polarity can be configured in software using the bidirectional serial port. The AD7710/AD7712 also contains self-calibration, system calibration and background calibration options and also allows the user to read and to write the on-chip calibration registers.

[^28]
## AD7710 FUNCTIONAL BLOCK DIAGRAM



## AD7712 FUNCTIONAL BLOCK DIAGRAM



CMOS construction ensures low power dissipation and a powerdown mode reduces the standby power consumption to only $100 \mu \mathrm{~W}$ typical (AD7712) and $7 \mu \mathrm{~W}$ typical (AD7710). The part is available in a 24 -pin, 0.3 inch wide, plastic and hermetic dual-in-line package (DIP) as well as a 24 -lead small outline (SOIC) package.
$\left(\mathrm{AV}_{\mathrm{DD}}=+5 \mathrm{~V} \pm 5 \% ; \mathrm{DV} \mathrm{DD}_{\mathrm{DD}}=+5 \mathrm{~V} \pm 5 \% ; \mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}\right.$ or $-5 \mathrm{~V} \pm 5 \%$;
AD7712-SPECIFICATIONS
REF $\operatorname{IN}(+)=+2.5 \mathrm{~V}$; REF $\operatorname{IN}(-)=$ AGND; MCLK $\operatorname{IN}=10 \mathrm{MHz}$ unless otherwise
stated. All specifications $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX, }}$, unless otherwise noted.)


NOTES
${ }^{1}$ Temperature ranges are as follows: A Version, $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; S Version, $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
${ }^{2}$ Applies after calibration at the temperature of interest.
${ }^{3}$ Positive full-scale error applies to both unipolar and bipolar input ranges.
${ }^{4}$ These errors will be of the order of the output noise of the part, as shown in Table I.
${ }^{5}$ Recalibration at any temperature or use of the background calibration mode will remove these drift errors.
${ }^{6}$ These numbers are guaranteed by design and/or characterization.
${ }^{7}$ This common-mode voltage range is allowed provided that the absolute value of the input voltage on AINl( + ) and AIN1( - ) does not exceed $\mathrm{AV}_{\mathrm{DD}}+30 \mathrm{mV}$ and $\mathrm{V}_{\mathrm{ss}}-30 \mathrm{mV}$.
${ }^{8}$ The AIN1 analog input presents a very high impedance dynamic load which varies with clock frequency and input sample rate. The maximum recommended source resistance depends on the selected gain (see Tables IV and V).
${ }^{9}$ The analog input voltage range on the $\mathrm{AINl}(+)$ input is given here with respect to the voltage on the AIN1(-) input. The input voltage range on the AIN2 input is with respect to AGND. The absolute voltage on the AIN1 input should not go more positive than $\mathrm{AV}_{\mathrm{DD}}+30 \mathrm{mV}$ or more negative than
$\mathrm{V}_{\mathrm{ss}}-30 \mathrm{mV}$.
${ }^{10} \mathrm{~V}_{\text {REF }}=$ REF IN $(+)-\operatorname{REF} \operatorname{IN}(-)$.

## AD7712-SPECIFICATIONS

| Parameter | A, S Versions ${ }^{1}$ | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: |
| REFERENCE OUTPUT <br> Output Voltage Initial Tolerance Drift Output Noise Line Regulation ( $\mathrm{AV}_{\mathrm{DD}}$ ) Load Regulation External Current | $\begin{array}{\|l} 2.5 \\ \pm 4 \\ 20 \\ 50 \\ 1 \\ 1.5 \\ 1 \end{array}$ | V nom $\%$ max $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ typ $\mu \mathrm{V}$ typ $\mathrm{mV} / \mathrm{V}$ max $\mathrm{mV} / \mathrm{mA} \max$ $m A$ max | pk-pk Noise; 0.1 Hz to 10 Hz Bandwidth <br> Maximum Load Current 1 mA |
| $\mathrm{V}_{\mathrm{BIAS}} \text { INPUT }^{13}$ <br> Input Voltage Range $\mathrm{V}_{\text {BIAS }} \text { Rejection }$ | $\begin{aligned} & \mathrm{AV}_{\mathrm{DD}}-0.85 \times \mathrm{V}_{\mathrm{REF}} \\ & \text { or } \mathrm{AV}_{\mathrm{DD}}-3 \\ & \text { or } \mathrm{AV}_{\mathrm{DD}}-2.1 \\ & \mathrm{~V}_{\mathrm{SS}}+0.85 \times \mathrm{V}_{\mathrm{REF}} \\ & \text { or } \mathrm{V}_{\mathrm{SS}}+3 \\ & \text { or } \mathrm{V}_{\mathrm{SS}}+2.1 \\ & 65 \text { to } 85 \end{aligned}$ | V max <br> $V_{\text {max }}$ <br> V min <br> V min dB typ | See $\mathrm{V}_{\text {bias }}$ Input Section <br> Whichever Is Smaller; $+5 \mathrm{~V} /-5 \mathrm{~V}$ or $+10 \mathrm{~V} / 0 \mathrm{~V}$ <br> Nominal $\mathrm{AV}_{\mathrm{DD}} / \mathrm{V}_{\mathrm{ss}}$ <br> Whichever Is Smaller; $+5 \mathrm{~V} / 0 \mathrm{~V}$ Nominal $\mathrm{AV}_{\mathrm{DD}} / \mathrm{V}_{\mathrm{ss}}$. <br> See $\mathrm{V}_{\text {bias }}$ Input Section <br> Whichever Is Greater; $+5 \mathrm{~V} /-5 \mathrm{~V}$ or $+10 \mathrm{~V} / 0 \mathrm{~V}$ <br> Nominal $\mathrm{AV}_{\mathrm{DD}} / \mathrm{V}_{\mathrm{ss}}$ <br> Whichever Is Greater; $+5 \mathrm{~V} / 0 \mathrm{~V}$ Nominal $\mathrm{AV}_{\mathrm{DD}} / \mathrm{V}_{\mathrm{Ss}}$ <br> Increasing with Gain |
| LOGIC INPUTS <br> Input Current <br> All Inputs Except MCLK IN <br> $\mathrm{V}_{\text {INL }}$, Input Low Voltage <br> $\mathrm{V}_{\text {INH }}$, Input High Voltage MCLK IN Only <br> $\mathrm{V}_{\text {INL }}$, Input Low Voltage <br> $\mathrm{V}_{\text {INH }}$, Input High Voltage | $\begin{aligned} & \pm 10 \\ & 0.8 \\ & 2.0 \\ & \\ & 0.8 \\ & 3.5 \end{aligned}$ | $\mu \mathrm{A}$ max <br> $V$ max <br> V min <br> $V_{\text {max }}$ <br> V min |  |
| LOGIC OUTPUTS <br> $\mathrm{V}_{\text {OL }}$, Output Low Voltage <br> $\mathrm{V}_{\mathrm{OH}}$, Output High Voltage <br> Floating State Leakage Current <br> Floating State Output Capacitance ${ }^{14}$ | $\begin{aligned} & 0.4 \\ & 4.0 \\ & \pm 10 \\ & 9 \end{aligned}$ | V max <br> $V$ min <br> $\mu \mathrm{A}$ max <br> pF typ | $\begin{aligned} & \mathrm{I}_{\text {SINK }}=1.6 \mathrm{~mA} \\ & \mathrm{I}_{\text {SOURCE }}=100 \mu \mathrm{~A} \end{aligned}$ |
| TRANSDUCER BURN-OUT <br> Current <br> Initial Tolerance <br> Drift | $\begin{aligned} & 100 \\ & \pm 10 \\ & 0.1 \end{aligned}$ | nA nom <br> \% typ <br> $\% /{ }^{\circ} \mathrm{C}$ typ |  |
| SYSTEM CALIBRATION <br> AIN1 <br> Positive Full-Scale Calibration Limit ${ }^{15}$ Negative Full-Scale Calibration Limit ${ }^{15}$ Offset Calibration Limit ${ }^{16,17}$ Input Span ${ }^{15}$ | $\begin{aligned} & \left(1.05 \times \mathrm{V}_{\mathrm{REF}}\right) / \mathrm{GAIN} \\ & -\left(1.05 \times \mathrm{V}_{\mathrm{REF}}\right) / \mathrm{GAIN} \\ & -\left(1.05 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}\right. \\ & 0.8 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN} \\ & \left(2.1 \times \mathrm{V}_{\mathrm{REF}} /\right. \text { GAIN } \end{aligned}$ | V max <br> V max <br> V max <br> $V$ min <br> V max | GAIN Is the Selected PGA Gain (Between 1 and 128) GAIN Is the Selected PGA Gain (Between 1 and 128) GAIN Is the Selected PGA Gain (Between 1 and 128) GAIN Is the Selected PGA Gain (Between 1 and 128) GAIN Is the Selected PGA Gain (Between 1 and 128) |
| AIN2 <br> Positive Full-Scale Calibration Limit ${ }^{15}$ Negative Full-Scale Calibration Limit ${ }^{15}$ Offset Calibration Limit ${ }^{17}$ Input Span | $\begin{aligned} & \left(4.2 \times \mathrm{V}_{\text {REF }}\right) / \text { /GAIN } \\ & -\left(4.2 \times \mathrm{V}_{\text {REF }} / / \mathrm{GAIN}\right. \\ & -\left(4.2 \times \mathrm{V}_{\text {REF }} /\right. \text { GAIN } \\ & 3.2 \times \mathrm{V}_{\text {REF }} / \mathrm{GAIN} \\ & \left(8.4 \times \mathrm{V}_{\mathrm{REF}}\right) / \mathrm{GAIN} \end{aligned}$ | $V_{\text {max }}$ <br> $V_{\text {max }}$ <br> V max <br> V min <br> V max | GAIN Is the Selected PGA Gain (Between 1 and 128) GAIN Is the Selected PGA Gain (Between 1 and 128) GAIN Is the Selected PGA Gain (Between 1 and 128) GAIN Is the Selected PGA Gain (Between 1 and 128) GAIN Is the Selected PGA Gain (Between 1 and 128) |

[^29]| Parameter | A, S Versions ${ }^{1}$ | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: |
| POWER REQUIREMENTS |  |  |  |
| Power Supply Voltages |  |  |  |
| AV ${ }_{\text {DD }}$ Voltage ${ }^{18}$ | +5 to +10 | $V$ nom | $\pm 5 \%$ for Specified Performance |
| DV DD $^{\text {Voltage }}{ }^{19}$ | +5 | $V$ nom | $\pm 5 \%$ for Specified Performance |
| AV $\mathrm{VD}_{\text {D }}-\mathrm{V}_{\text {SS }}$ Voltage | + 10.5 | V max | For Specified Performance |
| Power Supply Currents |  |  |  |
| $\mathrm{AV}_{\text {DD }}$ Current | 4 | $m A \max$ |  |
| $\mathrm{DV}_{\text {DD }}$ Current | 4.5 | $m A \max$ |  |
| $\mathrm{V}_{\text {SS }}$ Current | 1.5 | mA max | $\mathrm{V}_{\mathrm{SS}}=-5 \mathrm{~V}$ |
| Power Supply Rejection ${ }^{20}$ |  |  | Rejection w.r.t. AGND. Assumes V ${ }_{\text {bias }}$ Is Fixed |
| Positive Supply ( $\mathrm{AV}_{\mathrm{DD}}$ ) | See Note 21 | dB typ |  |
| Negative Supply ( $\mathrm{V}_{\text {SS }}$ ) | 90 | dB typ |  |
| Power Dissipation |  |  |  |
| Normal Mode | 45 | mW max |  |
| Normal Mode | 52.5 | mW max | $\begin{aligned} & \mathrm{AV}_{\mathrm{DD}}=\mathrm{DV} \mathrm{DD}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=-5 \mathrm{~V} \text {; Typically } 30 \mathrm{~mW} \\ & \mathrm{AV}_{\mathrm{DD}}=\mathrm{DV}_{\mathrm{DD}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V} \text { or }-5 \mathrm{~V} \text {; Typically } 100 \end{aligned}$ |
| Standby (Power-Down) Mode ${ }^{22}$ | 200 | $\mu \mathrm{W}$ max | $\mu \mathrm{W}$ |

${ }^{18}$ The AD7712 is specified with a 10 MHz clock for $\mathrm{AV}_{\mathrm{DD}}$ voltages of $+5 \mathrm{~V} \pm 5 \%$. It is specified with an 8 MHz clock for $\mathrm{AV}_{\mathrm{DD}}$ voltages greater than 5.25 V and less than 10.5 V . Operating with $\mathrm{AV}_{\mathrm{DD}}$ voltages in the range 5.25 V to 10.5 V is only guaranteed over the $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ temperature range.
${ }^{19}$ The $\pm 5 \%$ tolerance on the $\mathrm{DV}_{\mathrm{DD}}$ input is allowed provided $\mathrm{DV}_{\mathrm{DD}}$ does not exceed $A V_{D D}$ by more than 0.3 V .
${ }^{20}$ Measured at dc and applies in the selected passband. PSRR at 50 Hz will exceed 120 dB with filter notches of $10 \mathrm{~Hz}, 25 \mathrm{~Hz}$ or 50 Hz . PSRR at 60 Hz will exceed 120 dB with filter notches of $10 \mathrm{~Hz}, 30 \mathrm{~Hz}$ or 60 Hz .
${ }^{21}$ PSRR depends on gain: gain of $1=70 \mathrm{~dB}$ typ; gain of $2=75 \mathrm{~dB}$ typ; gain of $4=80 \mathrm{~dB}$ typ; gains of 8 to $128=85 \mathrm{~dB}$ typ. These numbers can be improved (to 95 dB typ) by deriving the $\mathrm{V}_{\text {BIAS }}$ voltage (via Zener diode or reference) from the $A V_{D D}$ supply.
${ }^{22}$ Using the hardware STANDBY pin. Standby power dissipation using the software standby bit (PD) of the Control Register is 5 mW typ.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS*

$\left(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right.$ unless otherwise noted)
$\mathrm{AV}_{\mathrm{DD}}$ to $\mathrm{DV}_{\mathrm{DD}} \ldots . . . . . . . . . . . . . .-0.3 \mathrm{~V}$ to +12 V

$\mathrm{AV}_{\mathrm{DD}}$ to AGND . . . . . . . . . . . . . . . . . . . -0.3 V to +12 V
$\mathrm{AV}_{\mathrm{DD}}$ to $\mathrm{DGND} . . . . . . . . . . . . . . . . .-0.3 \mathrm{~V}$ to +12 V
$\mathrm{DV}_{\mathrm{DD}}$ to AGND . . . . . . . . . . . . . . . . . . -0.3 V to +6 V
$\mathrm{DV}_{\mathrm{DD}}$ to DGND . . . . . . . . . . . . . . . . . . -0.3 V to +6 V
$\mathrm{V}_{\text {Ss }}$ to AGND . . . . . . . . . . . . . . . . . . . . . +0.3 V to -6 V
$\mathrm{V}_{\text {ss }}$ to DGND . . . . . . . . . . . . . . . . . . . . . +0.3 V to -6 V
AIN1 Input Voltage to AGND . $\mathrm{V}_{\mathrm{Ss}}-0.3 \mathrm{~V}$ to $\mathrm{AV}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Reference Input Voltage to AGND
$\ldots . . . . . . . . . . . . V_{S S}-0.3 \mathrm{~V}$ to $\mathrm{AV}_{\mathrm{DD}}+0.3 \mathrm{~V}$
REF OUT to AGND . . . . . . . . . . . . -0.3 V to $\mathrm{AV}_{\mathrm{DD}}$

Digital Input Voltage to DGND . . -0.3 V to $\mathrm{AV}_{\mathrm{DD}}+0.3 \mathrm{~V}$ Digital Output Voltage to DGND . . -0.3 V to $\mathrm{DV}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Operating Temperature Range
Commercial (A Version) . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Extended (S Version) . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 secs) . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Power Dissipation (Any Package) to $+75^{\circ} \mathrm{C}$. . . . . . . 450 mW
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are inserted.


ORDERING GUIDE

| Model | Temperature Range | Package Option |
| :--- | :--- | :--- |
| AD7712AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-24$ |
| AD7712AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-24$ |
| AD7712AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-24$ |
| AD7712SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-24$ |

* $\mathrm{N}=$ Plastic DIP; $\mathrm{Q}=$ Cerdip; $\mathrm{R}=$ SOIC. For outline information see Package Information section.
$\quad \mathrm{AV}_{\mathrm{DD}}=+5 \mathrm{~V} \pm 5 \% ; \mathrm{DV} \mathrm{DO}_{\mathrm{DD}}=+5 \mathrm{~V} \pm 5 \% ; \mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}$ or $-5 \mathrm{~V} \pm 5 \%$;
AD7710-SPECIFICATIONS
REF IN(+) $=+2.5 \mathrm{~V}$; REF IN( - ) = AGND; MCLK $\mathbb{N}=10 \mathrm{MHz}$ unless
otherwise stated. All specifications $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {Max }}$, unless otherwise noted.)

| Parameter | A, S Versions ${ }^{1}$ | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: |
| STATIC PERFORMANCE No Missing Codes | $\begin{aligned} & 24 \\ & 22 \\ & 18 \\ & 15 \\ & 12 \end{aligned}$ | Bits min <br> Bits min <br> Bits min <br> Bits min <br> Bits min | ```Guaranteed by Design. For Filter Notches \(\leq 60 \mathrm{~Hz}\) For Filter Notch \(=100 \mathrm{~Hz}\) For Filter Notch \(=250 \mathrm{~Hz}\) For Filter Notch \(=500 \mathrm{~Hz}\) For Filter Notch \(=1 \mathrm{kHz}\)``` |
| Output Noise | Tables I \& II |  | Depends on Filter Cutoffs and Selected Gain |
| Integral Nonlinearity <br> @ $25^{\circ} \mathrm{C}$ <br> $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ <br> Positive Full Scale Error ${ }^{2,3}$ <br> Full-Scale Drift ${ }^{5}$ | $\begin{aligned} & \pm 0.0045 \\ & \pm 0.0075 \\ & \text { See Note 4 } \\ & \text { 3/GAIN } \\ & 0.35 \end{aligned}$ | $\%$ of FSR max $\%$ of FSR max <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ | Filter Notches $\leq 60 \mathrm{~Hz}$; Typically $\pm 0.0015 \%$ <br> Filter Notches $\leq 60 \mathrm{~Hz}$ <br> Excluding Reference <br> Excluding Reference. For Gains of 1, 2, 4, 8 <br> Excluding Reference. For Gains of 16, 32, 64, 128 |
| Unipolar Offset Error ${ }^{2}$ Unipolar Offset Drift ${ }^{5}$ | $\begin{array}{\|l} \text { See Note } 4 \\ 2.5 / \mathrm{GAIN} \\ 0.3 \end{array}$ | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ | For Gains of $1,2,4,8$ <br> For Gains of 16, 32, 64, 128 |
| Bipolar Zero Error ${ }^{2}$ | See Note 4 |  |  |
| Bipolar Zero Drift ${ }^{5}$ | $\begin{aligned} & \text { 2.5/GAIN } \\ & 0.3 \end{aligned}$ | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ | For Gains of $1,2,4,8$ <br> For Gains of $16,32,64,128$ |
| Bipolar Negative Full-Scale Error ${ }^{2}$ Bipolar Negative Full-Scale Drift ${ }^{5}$ | $\begin{aligned} & \pm 0.006 \\ & 4 / \text { GAIN } \\ & 0.5 \end{aligned}$ | $\%$ of FSR max <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ | Excluding Reference; Typically $\pm 0.0015 \%$ <br> Excluding Reference. For Gains of 1, 2, 4, 8 <br> Excluding Reference. For Gains of 16, 32, 64, 128 |
| ANALOG INPUTS/REFERENCE INPUTS <br> Common-Mode Rejection (CMR) <br> Common-Mode Voltage Range ${ }^{6}$ <br> Normal Mode 50 Hz Rejection ${ }^{7}$ <br> Normal Mode 60 Hz Rejection ${ }^{7}$ <br> Common-Mode 50 Hz Rejection ${ }^{7}$ <br> Common-Mode 60 Hz Rejection ${ }^{7}$ <br> DC Input Leakage Current ${ }^{7} @+25^{\circ} \mathrm{C}$ <br> $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\mathrm{MAX}}$ <br> Sampling Capacitance ${ }^{7}$ <br> Analog Inputs ${ }^{8}$ <br> Input Voltage Range ${ }^{9}$ <br> Input Sampling Rate, fs <br> Reference Inputs <br> REF IN( + ) - REF IN( $(-)$ Voltage ${ }^{11}$ <br> Input Sampling Rate, $f_{s}$ | 92 <br> $\mathrm{V}_{\mathrm{SS}}$ to $\mathrm{AV}_{\mathrm{DD}}$ <br> 100 <br> 100 <br> 150 <br> 150 <br> 10 <br> 1 <br> 20 $\begin{aligned} & 0 \text { to }+V_{\mathrm{REF}}{ }^{10} \\ & \pm \mathrm{V}_{\mathrm{REF}} \end{aligned}$ <br> See Table III <br> +2.5 to +5 <br> $\mathrm{f}_{\text {CLK IN }} / 512$ | dB min <br> $\mathrm{V} \min$ to V max dB min dB min dB min dB min pA max nA max pF max <br> nom <br> nom <br> $\mathrm{V} \min$ to V max | At DC <br> For Filter Notches of $10,25,50 \mathrm{~Hz}, \pm 0.02 \times \mathrm{f}_{\text {NOTCH }}$ For Filter Notches of $10,30,60 \mathrm{~Hz}, \pm 0.02 \times \mathrm{f}_{\mathrm{NOTCH}}$ For Filter Notches of $10,25,50 \mathrm{~Hz}, \pm 0.02 \times \mathrm{f}_{\mathrm{NOTCH}}$ For Filter Notches of $10,30,60 \mathrm{~Hz}, \pm 0.02 \times \mathrm{f}_{\text {NOTCH }}$ <br> For Normal Operation. Depends on Gain Selected Unipolar Input Range ( $\mathrm{B} / \mathrm{U}$ Bit of Control Register $=1$ ) Bipolar Input Range ( $\mathrm{B} / \mathrm{U}$ Bit of Control Register $=0$ ) <br> For Specified Performance. Part Functions with Lower $\mathrm{V}_{\text {REF }}$ Voltages |
| REFERENCE OUTPUT <br> Output Voltage <br> Initial Tolerance <br> Drift <br> Output Noise <br> Line Regulation ( $\mathrm{AV}_{\mathrm{DD}}$ ) <br> Load Regulation <br> External Current | $\begin{array}{\|l} 2.5 \\ \pm 4 \\ 20 \\ 50 \\ 1 \\ 1.5 \\ 1 \end{array}$ | V nom <br> \% max <br> $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ typ <br> $\mu \mathrm{V}$ typ <br> $\mathrm{mV} / \mathrm{V}$ max <br> $\mathrm{mV} / \mathrm{mA}$ max <br> mA max | pk-pk Noise 0.1 Hz to 10 Hz Bandwidth <br> Maximum Load Current $\operatorname{lmA}$ |

[^30]| Parameter | A, S Versions ${ }^{1}$ | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: |
| $\overline{\mathrm{V}_{\text {BIAS }} \text { INPUT }^{12}}$ <br> Input Voltage Range $\mathrm{V}_{\text {BIAS }} \text { Rejection }$ | $\begin{aligned} & \mathrm{AV}_{\mathrm{DD}}-0.85 \times \mathrm{V}_{\mathrm{REF}} \\ & \text { or } \mathrm{AV} \mathrm{~V}_{\mathrm{DD}}-3 \\ & \text { or } \mathrm{AV}_{\mathrm{DD}}-2.1 \\ & \mathrm{~V}_{\mathrm{SS}}+0.85 \times \mathrm{V}_{\mathrm{REF}} \\ & \text { or } \mathrm{V}_{\mathrm{SS}}+3 \\ & \text { or } \mathrm{V}_{\mathrm{Ss}}+2.1 \\ & 65 \text { to } 85 \end{aligned}$ | $V \max$ $V \max$ $V \min$ $V \min$ $d B \operatorname{typ}$ | See $\mathrm{V}_{\text {bias }}$ Input Section <br> Whichever Is Smaller; $+5 \mathrm{~V} /-5 \mathrm{~V}$ or $+10 \mathrm{~V} / 0 \mathrm{~V}$ <br> Nominal $\mathrm{AV}_{\mathrm{DD}} / \mathrm{V}_{\mathrm{SS}}$ <br> Whichever Is Smaller; $+5 \mathrm{~V} / 0 \mathrm{~V}$ Nominal $\mathrm{AV}_{\mathrm{DD}} / \mathrm{V}_{\mathrm{SS}}$ <br> See V bias Input Section <br> Whichever Is Greater; $+5 \mathrm{~V} /-5 \mathrm{~V}$ or $+10 \mathrm{~V} / 0 \mathrm{~V}$ <br> Nominal $\mathrm{AV}_{\mathrm{DD}} / \mathrm{V}_{\mathrm{SS}}$ <br> Whichever Is Greater; $+5 \mathrm{~V} / 0 \mathrm{~V}$ Nominal $\mathrm{AV}_{\mathrm{DD}} / \mathrm{V}_{\text {Ss }}$ <br> Increasing with Gain |
| LOGIC INPUTS <br> Input Current <br> All Inputs Except MCLK IN <br> $\mathrm{V}_{\text {INL }}$, Input Low Voltage <br> $\mathrm{V}_{\text {INH }}$, Input High Voltage <br> MCLK IN Only <br> $\mathrm{V}_{\text {INL }}$, Input Low Voltage <br> $\mathrm{V}_{\text {INH }}$, Input High Voltage | $\pm 10$ 0.8 2.0 0.8 3.5 | $\mu \mathrm{A}$ max <br> V max <br> V min <br> V max <br> V min |  |
| LOGIC OUTPUTS <br> $\mathrm{V}_{\text {OL }}$, Output Low Voltage <br> $\mathrm{V}_{\mathrm{OH}}$, Output High Voltage <br> Floating State Leakage Current Floating State Output Capacitance ${ }^{13}$ | $\begin{aligned} & 0.4 \\ & \mathrm{DV} \\ & \pm \mathrm{DD} \\ & \pm 10 \\ & 9 \end{aligned}$ | $V \max$ <br> V min <br> $\mu \mathrm{A}$ max <br> pF typ | $\begin{aligned} & \mathrm{I}_{\text {SINK }}=1.6 \mathrm{~mA} \\ & \mathrm{I}_{\text {SOURCE }}=100 \mu \mathrm{~A} \end{aligned}$ |
| TRANSDUCER BURN-OUT <br> Current <br> Initial Tolerance <br> Drift | $\begin{aligned} & 100 \\ & \pm 10 \\ & 0.1 \end{aligned}$ | nA nom <br> \% typ <br> $\% /{ }^{\circ} \mathrm{C}$ typ |  |
| COMPENSATION CURRENT <br> Output Current <br> Initial Tolerance <br> Drift <br> Line Regulation ( $\mathrm{AV}_{\mathrm{DD}}$ ) <br> Load Regulation <br> Output Compliance | $\begin{aligned} & 20 \\ & \pm 4 \\ & 35 \\ & 20 \\ & 20 \\ & A V_{D D}-2 \end{aligned}$ | $\mu \mathrm{A}$ nom $\mu \mathrm{A}$ max $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ typ $n A / V \max$ nA/V max V max | $\mathrm{AV}_{\mathrm{DD}}=+5 \mathrm{~V}$ |
| SYSTEM CALIBRATION <br> Positive Full-Scale Calibration Limit ${ }^{14}$ Negative Full-Scale Calibration Limit ${ }^{14}$ Offset Calibration Limit ${ }^{15}$ Input Span ${ }^{15}$ | $\left\lvert\, \begin{aligned} & \left(1.05 \times \mathrm{V}_{\mathrm{REF}}\right) / \mathrm{GAIN} \\ & -\left(1.05 \times \mathrm{V}_{\mathrm{REF}}\right) / \mathrm{GAIN} \\ & -\left(1.05 \times \mathrm{V}_{\mathrm{REF}}\right) / \mathrm{GAIN} \\ & 0.8 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN} \\ & \left(2.1 \times \mathrm{V}_{\mathrm{REF}}\right) / \mathrm{GAIN} \\ & \hline \end{aligned}\right.$ | $\begin{aligned} & V \text { max } \\ & V \text { max } \\ & V \text { max } \\ & V \text { min } \\ & V \text { max } \end{aligned}$ | GAIN Is the Selected PGA Gain (Between 1 and 128) GAIN Is the Selected PGA Gain (Between 1 and 128) GAIN Is the Selected PGA Gain (Between 1 and 128) GAIN Is the Selected PGA Gain (Between 1 and 128) GAIN Is the Selected PGA Gain (Between 1 and 128) |

## NOTES

${ }^{12}$ The AD7710 is tested with the following $\mathrm{V}_{\text {BIAS }}$ voltages. With $\mathrm{AV}_{\mathrm{DD}}=+5 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{BIAS}}=+2.5 \mathrm{~V}$; with AV DD $=+10 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}$, $\mathrm{V}_{\text {BIAS }}=+5 \mathrm{~V}$ and with $A V_{\mathrm{DD}}=+5 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{SS}}=-5 \mathrm{~V}, \mathrm{~V}_{\text {BIAS }}=0 \mathrm{~V}$.
${ }^{13}$ Sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance.
${ }^{14}$ After calibration, if the analog input exceeds positive full scale, the converter will output all 1 s . If the analog input is less than negative full scale then the device will output all 0s.
${ }^{15}$ These calibration and span limits apply provided the absolute voltage on the analog inputs does not exceed $\mathrm{AV}_{\mathrm{DD}}+30 \mathrm{mV}$ or go more negative than $\mathrm{V}_{\mathrm{Ss}}-30 \mathrm{mV}$. The offset calibration limit applies to both the unipolar zero point and the bipolar zero point.

| Parameter | A, S Versions ${ }^{1}$ | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: |
| POWER REQUIREMENTS |  |  |  |
| Power Supply Voltages |  |  |  |
| $\mathrm{AV}_{\text {DD }}$ Voltage ${ }^{16}$ | +5 to +10 | V nom | $\pm 5 \%$ for Specified Performance |
| $\mathrm{DV}_{\mathrm{DD}}$ Voltage $^{17}$ | +5 | V nom | $\pm 5 \%$ for Specified Performance |
| $\mathrm{AV}_{\mathrm{DD}}-\mathrm{V}_{\text {Ss }}$ Voltage | +10.5 | V max | For Specified Performance |
| Power Supply Currents |  |  |  |
| $\mathrm{AV}_{\text {DD }}$ Current | 4 | mA max |  |
| $\mathrm{DV}_{\text {DD }}$ Current | 4.5 | $m A \max$ |  |
| $\mathrm{V}_{\text {ss }}$ Current | 1.5 | $m A \max$ | $\mathrm{V}_{\text {ss }}=-5 \mathrm{~V}$ |
| Power Supply Rejection ${ }^{18}$ |  |  | Rejection w.r.t. AGND; Assumes $\mathrm{V}_{\text {bias }}$ Is Fixed |
| Positive Supply ( $\mathrm{AV}_{\mathrm{DD}}$ ) | See Note 19 | dB typ |  |
| Negative Supply ( $\mathrm{V}_{\text {ss }}$ ) | 90 | dB typ |  |
| Power Dissipation |  |  |  |
| Normal Mode | 45 | mW max | $\mathrm{AV}_{\mathrm{DD}}=\mathrm{DV}_{\mathrm{DD}}=+5 \mathrm{~V}, \mathrm{~V}_{\text {SS }}=0 \mathrm{~V}$; Typically 25 mW |
| Normal Mode | 52.5 | mW max | $\mathrm{AV}_{\mathrm{DD}}=\mathrm{DV} \mathrm{DDD}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=-5 \mathrm{~V}$; Typically 30 mW |
| Standby (Power-Down) Mode | 15 | mW max | $\mathrm{AV}_{\mathrm{DD}}=\mathrm{DV} \mathrm{DD}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}$ or -5 V ; Typically 7 mW |

## NOTES

${ }^{16}$ The AD7710 is specified with a 10 MHz clock for $\mathrm{AV}_{\mathrm{DD}}$ voltages of $+5 \mathrm{~V} \pm 5 \%$. It is specified with an 8 MHz clock for $\mathrm{AV}_{\mathrm{DD}}$ voltages greater than 5.25 V and less than 10.5 V . Operation with $\mathrm{AV}_{\mathrm{DD}}$ voltages in the range 5.25 V to 10.5 V is only guaranteed over the 0 to $+70^{\circ} \mathrm{C}$ temperature range.
${ }^{17}$ The $\pm 5 \%$ tolerance on the $\mathrm{DV}_{\mathrm{DD}}$ input is allowed provided that $\mathrm{DV}_{\mathrm{DD}}$ does not exceed $\mathrm{AV}_{\mathrm{DD}}$ by more than 0.3 V .
${ }^{18}$ Measured at dc and applies in the selected passband. PSRR at 50 Hz will exceed 120 dB with filter notches of $10 \mathrm{~Hz}, 25 \mathrm{~Hz}$ or 50 Hz . PSRR at 60 Hz will exceed 120 dB with filter notches of $10 \mathrm{~Hz}, 30 \mathrm{~Hz}$ or 60 Hz .
${ }^{19}$ PSRR depends on gain: Gain of $1: 70 \mathrm{~dB}$ typ; Gain of 2: 75 dB typ; Gain of $4: 80 \mathrm{~dB}$ typ; Gains of 8 to $128: 85 \mathrm{~dB}$ typ. These numbers can be improved (to 95 dB typ) by deriving the $\mathrm{V}_{\text {BIAS }}$ voltage (via Zener diode or reference) from the $A V_{\mathrm{DD}}$ supply.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS*

( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted)


$A V_{D D}$ to AGND . . . . . . . . . . . . . . . . . . . . . -0.3 V to +12 V

$\mathrm{DV}_{\mathrm{DD}}$ to AGND . . . . . . . . . . . . . . . . . . . -0.3 V to +6 V
$\mathrm{DV}_{\mathrm{DD}}$ to DGND . . . . . . . . . . . . . . . . . . . -0.3 V to +6 V
$\mathrm{V}_{\text {ss }}$ to AGND . . . . . . . . . . . . . . . . . . . . . +0.3 V to -6 V
+0.3 V to -6 V
Analog Input Voltage to AGND
Reference Input Voltage to AGND
REF OUT to AGND . . . . . . . . . . . . . . . . -0.3 V to $\mathrm{AV}_{\mathrm{DD}}$

## CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are inserted.

Digital Input Voltage to DGND . . -0.3 V to $\mathrm{AV}_{\mathrm{DD}}+0.3 \mathrm{~V}$ Digital Output Voltage to DGND . . -0.3 V to $\mathrm{DV}_{\mathrm{DD}}+0.3 \mathrm{~V}$ Operating Temperature Range

Commercial (A Version) . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Extended (S Version) . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 secs) . . . . . . . . . . . $+300^{\circ} \mathrm{C}$ Power Dissipation (Any Package) to $+75^{\circ} \mathrm{C}$. . . . . . 450 mW Derates Above $+75^{\circ} \mathrm{C}$. . . . . . . . . . . . . . . . . . . . . $6 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## ORDERING GUIDE

| Model $^{\mathbf{1}}$ | Temperature Range | Package Option |
| :--- | :--- | :--- |
| AD7710AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-24$ |
| AD7710AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | R-24 |
| AD7710AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-24$ |
| AD7710SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-24$ |

[^31]$\left(\mathrm{DV}_{\mathrm{DD}}=+5 \mathrm{~V} \pm 5 \% ; \mathrm{AV}_{\mathrm{DD}}=+5 \mathrm{~V}\right.$ or $+10 \mathrm{~V}^{3} \pm 5 \% ; \mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}$ or $-5 \mathrm{~V} \pm 5 \%$;

| Parameter | Limit at $\mathrm{T}_{\text {MIN }}, \mathrm{T}_{\text {max }}$ (A, S Versions) | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: |
| $\mathrm{f}_{\text {CLK IN }}{ }^{4,5}$ |  |  | Master Clock Frequency: Crystal Oscillator or Externally Supplied |
|  | 400 | kHz min | $\mathrm{AV}_{\mathrm{DD}}=+5 \mathrm{~V} \pm 5 \%$ |
|  | 10 | MHz max | For Specified Performance |
|  | 8 | MHz max | $\mathrm{AV}_{\mathrm{DD}}=+5.25 \mathrm{~V}$ to +10.5 V |
| $\mathrm{t}_{\text {cle in }} \mathrm{LO}$ | $0.4 \times \mathrm{t}_{\text {CLK IN }}$ | ns min | Master Clock Input Low Time; $\mathrm{t}_{\text {CLK }}$ In $=1 / \mathrm{f}_{\text {CLK }}$ IN |
| $\mathrm{t}_{\text {CLK IN }} \mathrm{HI}$ | $0.4 \times \mathrm{t}_{\text {CLK }} \mathrm{IN}$ | ns min | Master Clock Input High Time |
| $\mathrm{t}_{\mathrm{r}}{ }^{6}$ | 50 | ns max | Digital Output Rise Time; Typically 20 ns |
| $\mathrm{t}_{\mathrm{f}}{ }^{6}$ | 50 | ns max | Digital Output Fall Time; Typically 20 ns |
| $\mathrm{t}_{1}$ | 1000 | ns min | SYNC Pulse Width |
| Self-Clocking Mode |  |  |  |
| $\mathrm{t}_{2}$ | 0 | ns min |  |
| $\mathrm{t}_{3}$ | 0 | ns min | DRDY to $\overline{\text { RFS }}$ Hold Time |
| $\mathrm{t}_{4}$ | $2 \times \mathrm{t}_{\text {CLK IN }}$ | ns min | A0 to $\overline{\mathrm{RFS}}$ Setup Time |
| $t_{5}$ | 50 | ns min | A0 to RFS Hold Time |
| $\mathrm{t}_{6}$ | $4 \times \mathrm{t}_{\text {CLK }} \mathrm{IN}$ | ns max | $\overline{\mathrm{RFS}}$ Low to SCLK Falling Edge |
| $\mathrm{t}_{7}{ }^{7}$ | $4 \times \mathrm{t}_{\text {cLK }} \mathrm{IN}$ | ns max | Data Access Time ( $\overline{\mathrm{RFS}}$ Low to Data Valid) |
| $\mathrm{t}_{8}{ }^{7}$ | $\begin{aligned} & \mathrm{t}_{\mathrm{CLK} \text { IN }} / 2 \\ & \mathrm{t}_{\mathrm{CLK} \text { IN }} / 2+30 \end{aligned}$ | ns min ns max | SCLK Falling Edge to Data Valid Delay |
| $\mathrm{t}_{9}$ | $\mathrm{t}_{\text {CLK IN }} / 2$ | ns nom | SCLK High Pulse Width |
| $\mathrm{t}_{10}$ | $3 \times \mathrm{t}_{\text {cLK IN }} / 2$ | ns nom | SCLK Low Pulse Width |
| $\mathrm{t}_{11}$ |  | ns min | $\overline{\mathrm{RFS}} / \overline{\mathrm{TFS}}$ to SCLK Falling Edge Hold Time |
|  | $\mathrm{t}_{\text {clk in }} / 2$ | ns max |  |
|  | $3 \times \mathrm{t}_{\text {CLK IN }} / 2+20$ | ns max | $\overline{\mathrm{RFS}} / \overline{\mathrm{TFS}}$ to SCLK Delay |
| $\mathrm{t}_{13}{ }^{8}$ | $3 \times \mathrm{t}_{\text {clk in }} / 2+20$ | ns max | $\overline{\mathrm{RFS}}$ to Data Valid Hold Time |
| $\mathrm{t}_{14}$ | 0 | ns min | A0 to TFS Setup Time |
| $\mathrm{t}_{15}$ |  | ns min | A0 to TFS Hold Time |
| $\mathrm{t}_{16}$ | $4 \times \mathrm{t}_{\text {cLK }} \mathrm{IN}$ | ns max | $\overline{\text { TFS }}$ to SCLK Falling Edge Delay Time |
| $\mathrm{t}_{17}$ | $4 \times \mathrm{t}_{\text {CLK }} \mathrm{IN}$ | ns min | TFS to SCLK Falling Edge Hold Time |
| $\mathrm{t}_{18}$ | 0 | ns min | Data Valid to SCLK Setup Time |
| $\mathrm{t}_{19}$ | 10 | $n \mathrm{nmin}$ | Data Valid to SCLK Hold Time |

# AGND $=$ DGND $=0 \mathbf{V} ; \mathrm{f}_{\text {CLKIN }}=10 \mathrm{MHz}$; Input Logic $\mathbf{0}=\mathbf{0} \mathbf{V}$, Logic $1=\mathrm{DV}_{\mathrm{DD}}$, unless otherwise stated.) <br> TIMING CHARACTERISTICS ${ }^{1,2}$ 



Figure 1. Load Circuit for Access Time and Bus Relinquish Time

| Parameter | Limit at $\mathrm{T}_{\text {MIN }}, \mathrm{T}_{\text {MAX }}$ (A, S Versions) | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: |
| External Clocking Mode |  |  |  |
| $\mathrm{f}_{\text {SCLK }}$ | $\mathrm{f}_{\text {CLK IN }} / 5$ | MHz max | Serial Clock Input Frequency |
| $\mathrm{t}_{20}$ | 0 | ns min | $\overline{\text { DRDY }}$ to RFS Setup Time |
| $\mathrm{t}_{21}$ | 0 | ns min | $\overline{\text { DRDY }}$ to $\overline{\text { RFS }}$ Hold Time |
| $\mathrm{t}_{22}$ | $2 \times \mathrm{t}_{\text {CLK }} \mathrm{IN}$ | ns min | A0 to RFS Setup Time |
| $\mathrm{t}_{23}$ | 50 | ns min | A0 to RFS Hold Time |
| $\mathrm{t}_{24}{ }^{7}$ | $4 \times \mathrm{t}_{\text {CLK }} \mathrm{IN}$ | ns max | Data Access Time ( $\overline{\mathrm{RFS}}$ Low to Data Valid) |
| $\mathrm{t}_{25}{ }^{7}$ | $\begin{aligned} & \mathrm{t}_{\mathrm{CLK} \text { IN }} / 2 \\ & 2 \times \mathrm{t}_{\mathrm{CLK} \mathrm{IN}}+20 \end{aligned}$ | ns min ns max | SCLK Falling Edge to Data Valid Delay |
| $\mathrm{t}_{26}$ | $2 \times \mathrm{t}_{\text {CLK }} \mathrm{IN}$ | ns min | SCLK High Pulse Width |
| $\mathrm{t}_{27}$ | $2 \times \mathrm{t}_{\text {CLK }} \mathrm{IN}$ | ns min | SCLK Low Pulse Width |
| $\mathrm{t}_{28}$ | $\mathrm{t}_{\text {CLK IN }}+10$ | ns max | SCLK Falling Edge to $\overline{\text { DRDY }}$ High |
| $\mathrm{t}_{29}{ }^{8}$ | 0 | ns min | $\overline{\text { DRDY }}$ to Data Valid Hold Time |
|  | 20 | ns max |  |
| $\mathrm{t}_{30}$ | 10 | $n \mathrm{nmin}$ | $\overline{\mathrm{RES}} / \overline{\mathrm{TFS}}$ to SCLK Falling Edge Hold Time |
| $\mathrm{t}_{31}{ }^{8}$ | $5 \times \mathrm{t}_{\text {CLK IN }} / 2+20$ | ns max | $\overline{\text { RFS }}$ to Data Valid Hold Time |
| $\mathrm{t}_{32}$ | 0 | ns min | A0 to TFS Setup Time |
| $\mathrm{t}_{33}$ | 0 | ns min | A0 to TFS Hold Time |
| $\mathrm{t}_{34}$ | $4 \times \mathrm{t}_{\text {CLK }} \mathrm{IN}$ | ns min | SCLK Falling Edge to TFS Hold Time |
| $\mathrm{t}_{35}$ | $5 \times \mathrm{t}_{\text {CLK }} \mathrm{IN} / 2-$ SCLK High | ns min | Data Valid to SCLK Setup Time |
| $\mathrm{t}_{36}$ | 30 | ns min | Data Valid to SCLK Hold Time |

NOTES
${ }^{1}$ Sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance. All input signals are specified with $\mathrm{t}_{\mathrm{R}}=\mathrm{t}_{\mathrm{F}}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of 5 V$)$ and timed from a voltage level of 1.6 V . ${ }^{2}$ See Figures 6 to 9 .
${ }^{3}$ The AD7710/AD7712 is specified with a 10 MHz clock for $\mathrm{AV}_{\mathrm{DD}}$ voltages of $+5 \mathrm{~V} \pm 5 \%$. It is specified with an 8 MHz clock for $\mathrm{AV}_{\mathrm{DD}}$ voltages greater than 5.25 V and less than 10.5 V . Operation with $\mathrm{AV}_{\mathrm{DD}}$ voltages in the range 5.25 V to 10.5 V is only guaranteed over the $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ temperature range.
${ }^{4}$ CLK IN duty cycle range is $45 \%$ to $55 \%$. CLK IN must be supplied whenever the AD7710/AD7712 is not in STANDBY mode. If no clock is present in this case, the device can draw higher current than specified and possibly become uncalibrated.
${ }^{5}$ The AD7710/AD7712 is production tested with $\mathrm{f}_{\text {CLK }}$ in at $10 \mathrm{MHz}\left(8 \mathrm{MHz}\right.$ for $\left.\mathrm{AV}_{\mathrm{DD}}<+5.25 \mathrm{~V}\right)$. It is guaranteed by characterization to operate at 400 kHz . ${ }^{6}$ Specified using $10 \%$ and $90 \%$ points on waveform of interest.
${ }^{7}$ These numbers are measured with the load circuit of Figure 1 and defined as the time required for the output to cross 0.8 V or 2.4 V .
${ }^{8}$ These numbers are derived from the measured time taken by the data output to change 0.5 V when loaded with the circuit of Figure 1 . The measured number is then extrapolated back to remove effects of charging or discharging the 100 pF capacitor. This means that the times quoted in the timing characteristics are the true bus relinquish times of the part and, as such, are independent of external bus loading capacitances.

PIN CONFIGURATION DIP and SOIC


| SCLK 1 | AD7712TOP VIEW(Not to Scale) | 24 | DGND |
| :---: | :---: | :---: | :---: |
| MCLKIN 2 |  | 23 | DV ${ }_{\text {DD }}$ |
| MCLK OUT 3 |  | 22 | SDATA |
| AO 4 |  | 21 | $\overline{\text { DRDY }}$ |
| SYNC 5 |  | 20 | $\overline{\text { RFS }}$ |
| MODE 6 |  | 19 | TFS |
| AIN1(+) 7 |  | 18 | AGND |
| AIN1(-) 8 |  | 17 | AIN2 |
| $\overline{\text { STANDBY }} 9$ |  | 16 | REF OUT |
| TP 10 |  | 15 | REF IN( + ) |
| $\mathrm{V}_{\text {ss }} 11$ |  | 14 | REF IN(-) |
| $\mathrm{AV}_{\mathrm{DD}} 12$ |  | 13 | $v_{\text {BIAS }}$ |

## PIN FUNCTION DESCRIPTION

| Pin | Mnemonic | Function |
| :---: | :---: | :---: |
| 1 | SCLK | Serial Clock. Logic Input/Output depending on the status of the MODE pin. When MODE is high, the device is in its self-clocking mode and the SCLK pin provides a serial clock output. This SCLK becomes active when $\overline{\mathrm{RFS}}$ or $\overline{\mathrm{TFS}}$ goes low and it goes high impedance when either $\overline{\mathrm{RFS}}$ or $\overline{\mathrm{TFS}}$ returns high or when the device has completed transmission of an output word. When MODE is low, the device is in its external clocking mode and the SCLK pin acts as an input. This input serial clock can be a continuous clock with all data transmitted in a continuous train of pulses. Alternatively, it can be a noncontinuous clock with the information being transmitted to the AD7710/AD7712 in smaller batches of data. |
| 2 | MCLK IN | Master Clock signal for the device. This can be provided in the form of a crystal or external clock. A crystal can be tied across the MCLK IN and MCLK OUT pins. Alternatively, the MCLK IN pin can be driven with a CMOS-compatible clock and MCLK.OUT left unconnected. The clock input frequency is nominally 10 MHz . |
| 3 | MCLK OUT | When the master clock for the device is a crystal, the crystal is connected between MCLK IN and MCLK OUT. |
| 4 | A0 | Address Input. With this input low, reading and writing to the device is to the control register. With this input high, access is to either the data register or the calibration registers. |
| 5 | $\overline{\text { SYNC }}$ | Logic Input which allows for synchronization of the digital filters when using a number of AD7710/AD7712s. It resets the nodes of the digital filter. |
| 6 | MODE | Logic Input. When this pin is high, the device is in its self-clocking mode; with this pin low, the device is in its external clocking mode. |
| 7 | AIN1(+) | Analog Input Channel 1. Positive input of the programmable gain differential analog input. The AIN1 $(+)$ input is connected to an output current source which can be used to check that an external transducer has burnt out or gone open circuit. This output current source can be turned on/off via the control register. |
| 8 | AIN1(-) | Analog Input Channel 1. Negative input of the programmable gain differential analog input. |
| 9 | AIN2(+) | AD7710 Only. Analog Input Channel 2. Positive input of the programmable gain differential analog input. |
| 9 | STANDBY | AD7712 Only. Logic Input. Taking this pin low shuts down the internal analog and digital circuitry, reducing power consumption to less than $50 \mu \mathrm{~W}$. |
| 10 | AIN2(-) | AD7710 Only. Analog Input Channel 2. Negative input of the programmable gain differential analog input. |
| 10 | TP | AD7712 Only. Test Pin. Used when testing the device. Do not connect anything to this pin. |
| 11 | $\mathrm{V}_{\mathrm{Ss}}$ | Analog Negative Supply, 0 V to -5 V . Tied to AGND for single supply operation. The input voltage on AIN1 should not go $>30 \mathrm{mV}$ negative w.r.t. $\mathrm{V}_{\text {SS }}$ for correct operation of the device. |
| 12 | $\mathrm{AV}_{\text {DD }}$ | Analog Positive Supply Voltage, +5 V to +10 V . |
| 13 | $\mathrm{V}_{\text {BIAS }}$ | Input Bias Voltage. This input voltage should be set such that $\mathrm{V}_{\text {BIAS }}+0.85 \times \mathrm{V}_{\mathrm{REF}}<\mathrm{AV}_{\mathrm{DD}}$ and $\mathrm{V}_{\text {BIAS }}-0.85 \times \mathrm{V}_{\text {REF }}>\mathrm{V}_{\text {SS }}$ where $\mathrm{V}_{\text {REF }}$ is REF IN(+) - REF IN( - ). Ideally, this should be tied halfway between $A V_{D D}$ and $\mathrm{V}_{\text {Ss }}$. Thus, with $A V_{D D}=+5 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{Ss}}=0$, it can be tied to REF OUT; with $A V_{D D}=+5 \mathrm{~V}$ and $\mathrm{V}_{\text {SS }}=-5 \mathrm{~V}$, it can be tied to AGND , while with $A V_{D D}=+10 \mathrm{~V}$, it can be tied to +5 V or to REF OUT. |
| 14 | REF IN(-) | Reference Input. The REF IN( - ) can lie anywhere between $\mathrm{AV}_{\text {DD }}$ and $\mathrm{V}_{\text {Ss }}$ provided REF $\operatorname{IN}(+)$ is greater than REF IN(-). |
| 15 | REF IN(+) | Reference Input. The reference input is differential providing that REF IN $(+)$ is greater than REF $\mathrm{IN}(-)$. REF IN( + ) can lie anywhere between $\mathrm{AV}_{\mathrm{DD}}$ and $\mathrm{V}_{\text {Ss }}$. |
| 16 | REF OUT | Reference Output. The internal +2.5 V reference is provided at this pin. This is a single-ended output which is referred to AGND. |
| 17 | $\mathrm{I}_{\text {OUT }}$ | AD7710 Only. Compensation Current Output. A $20 \mu \mathrm{~A}$ constant current is provided at this pin. This current can be used in conjunction with an external thermistor to provide cold junction compensation. |
| 17 | AIN2 | AD7712 Only. Analog Input Channel 2. High level analog input which accepts an analog input voltage range of $\pm 4 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}$. At the nominal $\mathrm{V}_{\mathrm{REF}}$ of +2.5 V and a gain of 1 , the AIN2 input voltage range is $\pm 10 \mathrm{~V}$. |
| 18 | AGND | Ground reference point for analog circuitry. |


| Pin | Mnemonic | Function |
| :---: | :---: | :---: |
| 19 | $\overline{\mathrm{TFS}}$ | Transmit Frame Synchronization. Active low logic input used to write serial data to the device with serial data expected after the falling edge of this pulse. In the self-clocking mode, the serial clock becomes active after TFS goes low. In the external clocking mode, TFS must go low before the first bit of the data word is written to the part. |
| 20 | $\overline{\text { RFS }}$ | Receive Frame Synchronization. Active low logic input used to access serial data from the device. In the self-clocking mode, the SCLK and SDATA lines both become active after $\overline{\mathrm{RFS}}$ goes low. In the external clocking mode, the SDATA line becomes active after $\overline{\mathrm{RFS}}$ goes low. |
| 21 | $\overline{\text { DRDY }}$ | Logic output. A falling edge indicates that a new output word is available for transmission. The $\overline{\mathrm{DRDY}}$ pin will return high upon completion of transmission of a full output word. $\overline{\mathrm{DRDY}}$ is also used to indicate when the AD7710/AD7712 has completed its on-chip calibration sequence. |
| 22 | SDATA | Serial Data. Input/Output with serial data being written to the control register or the calibration registers and serial data being accessed from the control register, calibration registers or the data register. During an output data read operation, serial data becomes active after $\overline{\mathrm{RFS}}$ goes low (provided $\overline{\mathrm{DRDY}}$ is low). During a write operation, valid serial data is expected on the rising edges of SCLK when TFS is low. The output data coding is natural binary for unipolar inputs and offset binary for bipolar inputs. |
| 23 | DV ${ }_{\text {DD }}$ | Digital Supply Voltage, $+5 \mathrm{~V} . \mathrm{DV}_{\mathrm{DD}}$ should never exceed $\mathrm{AV}_{\mathrm{DD}}$ by more than 0.3 V . If $\mathrm{DV}_{\mathrm{DD}}$ powers up before $\mathrm{AV}_{\mathrm{DD}}$, or if $\mathrm{DV}_{\mathrm{DD}}$ can exceed $A V_{\mathrm{DD}}$ by more than 0.3 V at any other time, the protection scheme outlined in Figure 5 should be used. |
| 24 | DGND | Ground reference point for digital circuitry. |

## TERMINOLOGY

## INTEGRAL NONLINEARITY

This is the maximum deviation of any code from a straight line passing through the endpoints of the transfer function. The endpoints of the transfer function are zero scale (not to be confused with bipolar zero), a point 0.5 LSB below the first code transition ( $000 \ldots 000$ to $000 \ldots 001$ ) and full-scale, a point 0.5 LSB above the last code transition (111 . . . 110 to 111 . . . 111).
The error is expressed as a percentage of full scale.

## POSITIVE FULL-SCALE ERROR

Positive full-scale error is the deviation of the last code transition (111 . . . 110 to 111 . . . 111) from the ideal input full-scale voltage. For AIN( + ), ${ }^{\star}$ the ideal full-scale input voltage is (AIN(-) $+\mathrm{V}_{\text {REF }} /$ GAIN $-3 / 2$ LSBs); for AIN2 of AD7712, the ideal full-scale voltage is $+4 \times \mathrm{V}_{\mathrm{REF}} /$ GAIN $-3 / 2$ LSBs. Positive full-scale error applies to both unipolar and bipolar analog input ranges.

## UNIPOLAR OFFSET ERROR

Unipolar offset error is the deviation of the first code transition from the ideal input voltage. For $\operatorname{AIN}(+)$, the ideal input voltage is ( $\operatorname{AIN}(-)+0.5 \mathrm{LSB})$; for AIN2 of AD7712, the ideal input is 0.5 LSB when operating in the unipolar mode.

## BIPOLAR ZERO ERROR

This is the deviation of the midscale transition ( 0111 . . . 111 to 1000 . . . 000) from the ideal input voltage. For AIN( + ), the ideal input voltage is (AIN(-) -0.5 LSB); for AIN2 of AD7712, the ideal input voltage is -0.5 LSB when operating in the bipolar mode.

## BIPOLAR NEGATIVE FULL-SCALE ERROR

This is the deviation of the first code transition from the ideal input voltage. For AIN(+), the ideal input voltage is (AIN(-) $-\mathrm{V}_{\text {REF }} /$ GAIN +0.5 LSB ); for AIN2 of AD7712, the ideal input voltage is ( $-4 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}+0.5 \mathrm{LSB}$ ) when operating in the bipolar mode.

## POSITIVE FULL-SCALE OVERRANGE

Positive full-scale overrange is the amount of overhead available to handle input voltages on $\operatorname{AIN}(+)$ input greater than (AIN(-) $+\mathrm{V}_{\text {REF }} / \mathrm{GAIN}$ ) or on AIN2 of AD7712 of greater than $+4 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}$ (for example, noise peaks or excess voltages due to system gain errors in system calibration routines) without introducing errors due to overloading the analog modulator or overflowing the digital filter.

## NEGATIVE FULL-SCALE OVERRANGE

This is the amount of overhead available to handle voltages on $\operatorname{AIN}\left(+\right.$ ) below (AIN(-) $-\mathrm{V}_{\text {REF }} / \mathrm{GAIN}$ ) or on AIN2 of AD7712 below $-4 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}$ without overloading the analog modulator or overflowing the digital filter. Note that the analog input will accept negative voltage peaks on $\mathrm{AINl}(+)$ even in the unipolar mode provided that $\operatorname{AIN}(+)$ is greater than $\operatorname{AIN}(-)$ and greater than $\mathrm{V}_{\mathrm{ss}}-30 \mathrm{mV}$.

## OFFSET CALIBRATION RANGE

In the system calibration modes, the AD7710/AD7712 calibrates its offset with respect to the analog input. The offset calibration range specification defines the range of voltages that the AD7710/AD7712 can accept and still calibrate offset accurately.

## FULL-SCALE CALIBRATION RANGE

This is the range of voltages that the AD7710/AD7712 can accept in the system calibration mode and still calibrate full scale correctly.

## INPUT SPAN

In system calibration schemes, two voltages applied in sequence to the AD7710/AD7712's analog input define the analog input range. The input span specification defines the minimum and maximum input voltages from zero to full-scale that the AD7710/AD7712 can accept and still calibrate gain accurately.

[^32]
## CONTROL REGISTER ( $\mathbf{2 4}$ BITS)

A write to the device with the A0 input low writes data to the control register. A read to the device with the A0 input low accesses the contents of the control register. The control register is 24 -bits wide and when writing to the register 24 bits of data must be written otherwise the data will not be loaded to the control register. In other words, it is not possible to write just the first 12-bits of data into the control register. If more than 24 clock pulses are provided before TFS returns high, then all clock pulses after the 24th clock pulse are ignored. Similarly, a read operation from the control register should access 24 bits of data.
MSB

| MD2 | MD1 | MD0 | G2 | G1 | G0 | CH | PD | WL | IO $^{1}$ | BO | B/U |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| FS11 FS10 FS9 FS8 FS7 FS6 FS5 FS4 FS3 FS2 FS1 FS0 |  |  |  |  |  |  |  |  |  |  |  |

[^33]| Operating Mode |  |  |  |
| :--- | :--- | :--- | :--- | :--- |
| MD2 | MD1 | MD0 | Operating Mode | O

```
PGA Gain
\begin{tabular}{lllll} 
G2 & G1 & G0 & Gain & \\
0 & 0 & 0 & 1 & (Default Condition After the Internal Power-On Reset) \\
0 & 0 & 1 & 2 & \\
0 & 1 & 0 & 4 & \\
0 & 1 & 1 & 8 & \\
1 & 0 & 0 & 16 & \\
1 & 0 & 1 & 32 & \\
1 & 1 & 0 & 64 & \\
1 & 1 & 1 & 128 &
\end{tabular}
```


## Channel Selection

## CH Channe

```
\begin{tabular}{lll}
\begin{tabular}{lll}
0 & AIN1 & Low Level Input \\
1 & AIN2 & High Level Input
\end{tabular} \\
Power-Down & \\
PD & \\
0 & Normal Operation & \\
1 & Power-Down \\
Word Length \\
WL & Output Word Length \\
0 & 16-Bit & (Default Condition After the Internal Power-On Reset) \\
1 & 24-Bit Condition After Internal Power-On Reset)
\end{tabular}
Output Compensation Current (AD7710 Only) IO
0 Off (Default Condition After Internal Power-On Reset)
1 On
```


## Burn-Out Current

```
BO
\begin{tabular}{lll}
0 & Off & (Default Condition After Internal Power-On Reset) \\
1 & On
\end{tabular}
```


## Bipolar/Unipolar Selection (Both Inputs)

```
B/U
0 Bipolar (Default Condition After Internal Power-On Reset)
1 Unipolar
```


## Filter Selection (FS11-FS0)

The on-chip digital filter provides a $\operatorname{Sinc}^{3}\left(\operatorname{or}(\operatorname{Sin} x / x)^{3}\right)$ filter response. The 12 bits of data programmed into these bits determine the filter cutoff frequency, the position of the first notch of the filter and the data rate for the part. In association with the gain selection, it also determines the output noise (and hence the effective resolution) of the device.
The first notch of the filter occurs at a frequency determined by the relationship: filter first notch frequency $=\left(\mathrm{f}_{\mathrm{CLK}} \mathrm{IN} / 512\right) /$ code where code is the decimal equivalent of the code in bits FS0 to FS11 and is in the range 19 to 2,000 . With the nominal $\mathrm{f}_{\mathrm{CLK}}$ in of 10 MHz , this results in a first notch frequency range from 9.76 Hz to 1.028 kHz . To ensure correct operation of the part, the value of the code loaded to these bits must be within this range. Failure to do this will result in unspecified operation of the device.
Changing the filter notch frequency, as well as the selected gain, impacts resolution. Tables I and II show the effect of the filter notch frequency and gain on the effective resolution of the part. The output data rate (or effective conversion time) for the device is equal to the frequency selected for the first notch of the filter. For example, if the first notch of the filter is selected at 50 Hz , then a new word is available at a 50 Hz rate or every 20 ms . If the first notch is at 1 kHz , a new word is available every 1 ms .

The settling time of the filter to a full-scale step input change is worst case $4 \times 1 /$ (output data rate). This settling time is to $100 \%$ of the final value. For example, with the first filter notch at 50 Hz , the settling time of the filter to a full-scale step input change is 80 ms max. If the first notch is at 1 kHz , the settling time of the filter to a full-scale input step is 4 ms max. This settling time can be reduced to $3 \times 1$ /(output data rate) by synchronizing the step input change to a reset of the digital filter. In other words, if the step input takes place with SYNC low, the settling time will be $3 \times 1 /$ (output data rate). If a change of channel takes place, the settling time is $3 \times 1 /$ (output data rate) regardless of the $\overline{\mathrm{SYNC}}$ input, but $\overline{\mathrm{DRDY}}$ does not stay high for $3 \times 1 /$ output rate.

The -3 dB frequency is determined by the programmed first notch frequency according to the relationship: filter -3 dB frequency $=0.262 \times$ first notch frequency, but DRDY does not stay high for $3 \times 1 /$ output rate.

Tables I and II show the output rms noise for some typical notch and -3 dB frequencies. The numbers given are for the bipolar input ranges with a $\mathrm{V}_{\mathrm{REF}}$ of +2.5 V . These numbers are typical and are generated with an analog input voltage of 0 V . The output noise from the part comes from two sources. First, there is the electrical noise in the semiconductor devices used in the implementation of the modulator (device noise). Secondly, when the analog input signal is converted into the digital domain, quantization noise is added. The device noise is at a low level and is largely independent of frequency. The quantization noise starts at an even lower level but rises rapidly with increasing frequency to become the dominant noise source. Consequently, lower filter notch settings (below 60 Hz approximately) tend to be device noise dominated while higher notch settings are dominated by quantization noise. Changing the filter notch and cutoff frequency in the quantization noise dominated region results in a more dramatic improvement in noise performance than it does in the device noise dominated region as shown in Table I. Furthermore, quantization noise is added after the PGA, so effective resolution is independent of gain for the higher filter notch frequencies. Meanwhile, device noise is added in the PGA, and therefore effective resolution suffers a little at high gains for lower notch frequencies.
At the lower filter notch settings (below 60 Hz ), the no missing codes performance of the device is at the 24 -bit level. At the higher settings, more codes will be missed until at 1 kHz notch setting, no missing codes performance is only guaranteed to the 12 -bit level. However, since the effective resolution of the part is 10.5 bits for this filter notch setting, this no missing codes performance should be more than adequate for all applications.
The effective resolution of the device is defined as the ratio of the output rms noise to the input full scale. This does not remain constant with increasing gain or with increasing bandwidth. Table II shows the same table as Table I except that the output is now expressed in terms of effective resolution (the magnitude of the rms noise with respect to $2 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}$, i.e., the input full scale). It is possible to do post filtering on the device to improve the output data rate for a given -3 dB frequency and also to further reduce the output noise (see Digital Filtering section).

Table I. Output Noise vs. Gain and First Notch Frequency

| First Notch of Filter and O/P Data Rate ${ }^{1}$ | $-3 \mathrm{~dB}$ <br> Frequency | Typical Output RMS Noise ( $\mu \mathrm{V}$ ) |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Gain of 1 | Gain of 2 | Gain of 4 | Gain of 8 | Gain of 16 | Gain of 32 | Gain of 64 | Gain of $128$ |
| $10 \mathrm{~Hz}^{2}$ | 2.62 Hz | 1.7 | 1.0 | 0.5 | 0.36 | 0.36 | 0.36 | 0.36 | 0.36 |
| $25 \mathrm{~Hz}^{2}$ | 6.55 Hz | 4.9 | 2.2 | 1.2 | 0.6 | 0.36 | 0.36 | 0.36 | 0.36 |
| $30 \mathrm{~Hz}^{2}$ | 7.86 Hz | 6.1 | 2.4 | 1.2 | 0.84 | 0.5 | 0.36 | 0.36 | 0.36 |
| $50 \mathrm{~Hz}^{2}$ | 13.1 Hz | 7.5 | 3.8 | 2.0 | 1.0 | 0.6 | 0.5 | 0.5 | 0.45 |
| $60 \mathrm{~Hz}^{2}$ | 15.72 Hz | 8.5 | 4.0 | 2.0 | 1.0 | 0.6 | 0.5 | 0.5 | 0.45 |
| $100 \mathrm{~Hz}^{3}$ | 26.2 Hz | 13 | 6.4 | 3.7 | 1.8 | 1.1 | 0.9 | 0.65 | 0.65 |
| $250 \mathrm{~Hz}^{3}$ | 65.5 Hz | 130 | 75 | 25 | 12 | 7.5 | 4 | 2.7 | 1.7 |
| $500 \mathrm{~Hz}^{3}$ | 131 Hz | $0.6 \times 10^{3}$ | $0.26 \times 10^{3}$ | 140 | 70 | 35 | 25 | 15 | 8 |
| $1 \mathrm{kHz}^{3}$ | 262 Hz | $3.1 \times 10^{3}$ | $1.6 \times 10^{3}$ | $0.7 \times 10^{3}$ | $0.29 \times 10^{3}$ | 180 | 120 | 70 | 40 |

NOTES
${ }_{2}^{1}$ The default condition (after the internal power-on reset) for the first notch of filter is 60 Hz .
${ }^{2}$ For these filter notch frequencies, the output rms noise is primarily dominated by device noise and as a result is independent of the value of the reference voltage. Therefore, increasing the reference voltage will give an increase in the effective resolution of the device (i.e., the ratio of the rms noise to the input full scale is increased since the output rms noise remains constant as the input full-scale increases).
${ }^{3}$ For these filter notch frequencies, the output rms noise is dominated by quantization noise and as a result is proportional to the value of the reference voltage.
Table II. Effective Resolution vs. Gain and First Notch Frequency

| First Notch of Filter and O/P Data Rate | $-3 \mathrm{~dB}$ <br> Frequency | Effective Resolution ${ }^{1}$ (Bits) |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Gain of 1 | Gain of 2 | Gain of 4 | Gain of 8 | Gain of 16 | Gain of 32 | Gain of 64 | Gain of $128$ |
| 10 Hz | 2.62 Hz | 21.5 | 21.5 | 21.5 | 20.5 | 19.5 | 18.5 | 17.5 | 16.5 |
| 25 Hz | 6.55 Hz | 20 | 20 | 20 | 20 | 19.5 | 18.5 | 17.5 | 16.5 |
| 30 Hz | 7.86 Hz | 19.5 | 20 | 20 | 19.5 | 19.5 | 18.5 | 17.5 | 16.5 |
| 50 Hz | 13.1 Hz | 19.5 | 19.5 | 19.5 | 19.5 | 19 | 18.5 | 17.5 | 16.5 |
| 60 Hz | 15.72 Hz | 19 | 19.5 | 19.5 | 19.5 | 19 | 18.5 | 17.5 | 16.5 |
| 100 Hz | 26.2 Hz | 18.5 | 18.5 | 18.5 | 18.5 | 18 | 17.5 | 17 | 16 |
| 250 Hz | 65.5 Hz | 15 | 15 | 15.5 | 15.5 | 15.5 | 15.5 | 15 | 14.5 |
| 500 Hz | 131 Hz | 13 | 13 | 13 | 13 | 13 | 12.5 | 12.5 | 12.5 |
| 1 kHz | 262 Hz | 10.5 | 10.5 | 11 | 11 | 11 | 10.5 | 10 | 10 |

## NOTE

${ }^{1}$ Effective resolution is defined as the magnitude of the output rms noise with respect to the input full scale (i.e., $2 \times \mathrm{V}_{\text {REF }} / \mathrm{GAIN}$ ). The above table applies for a $\mathrm{V}_{\mathrm{REF}}$ of +2.5 V and resolution numbers are rounded to the nearest 0.5 LSB .

## AD7710/AD7712

## CIRCUIT DESCRIPTION

The AD7710/AD7712 is a sigma-delta A/D converter with on-chip digital filtering, intended for the measurement of wide dynamic range, low frequency signals such as those in industrial control or process control applications. It contains a sigma-delta (or charge balancing) ADC, a calibration microcontroller with on-chip static RAM, a clock oscillator, a digital filter and a bidirectional serial communications port.
The part contains two programmable gain analog input channels. The gain range on both inputs is from 1 to 128 . For the differential inputs, this means that the input can accept unipolar signals of between 0 mV to +20 mV and 0 mV to +2.5 V or bipolar signals in the range from $\pm 20 \mathrm{mV}$ to $\pm 2.5 \mathrm{~V}$ when the reference input voltage equals +2.5 V . The input voltage range for the AIN2 input of the AD7712 is $\pm 4 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}$ and is $\pm 10 \mathrm{~V}$ with the nominal reference of +2.5 V and a gain of 1 . The input signal to the selected analog input channel is continuously sampled at a rate determined by the frequency of the master clock, CLK IN, and the selected gain (see Table III). A charge balancing A/D converter (Sigma-Delta Modulator) converts the sampled signal into a digital pulse train whose duty cycle contains the digital information. The programmable gain function on the analog input is also incorporated in this sigmadelta modulator with the input sampling frequency being modified to give the higher gains. A sinc ${ }^{3}$ digital low-pass filter processes the output of the sigma-delta modulator and updates the output register at a rate determined by the first notch frequency of this filter. The output data can be read from the serial port randomly or periodically at any rate up to the output register update rate. The first notch of this digital filter (and hence its -3 dB frequency) can be programmed via an on-chip control register. The programmable range for this first notch frequency is from 9.76 Hz to 1.028 kHz , giving a programmable range for the -3 dB frequency of 2.58 Hz to 269 Hz .
The AD7710/AD7712 provides a number of calibration options which can be programmed via the on-chip control register. A calibration cycle may be initiated at any time by writing to this control register. The part can perform self-calibration using the on-chip calibration microcontroller and SRAM to store calibration parameters. Other system components may also be included in the calibration loop to remove offset and gain errors in the input channel using the system calibration mode. Another option is a background calibration mode where the part continuously performs self-calibration and updates the calibration coefficients. Once the part is in this mode, the user does not have to worry about issuing periodic calibration commands to the device or asking the device to recalibrate when there is a change in the ambient temperature or power supply voltage.

The AD7710/AD7712 gives the user access to the on-chip calibration registers allowing the microprocessor to read the device's calibration coefficients and also to write its own calibration coefficients to the part from prestored values in E2PROM. This gives the microprocessor much greater control over the part's calibration procedure. It also means that the user can verify that the device has performed its calibration correctly by comparing the coefficients after calibration with prestored values in $E^{2}$ PROM.

The AD7710/AD7712 can be operated in single supply systems provided that the analog input voltage on the differential inputs does not go more negative than -30 mV . For larger bipolar signals on the differential inputs, a $\mathrm{V}_{\mathrm{SS}}$ of -5 V is required by the part. For battery operation or low power systems, the part offers a standby mode that reduces idle power consumption to typically $100 \mu \mathrm{~W}$ on AD7712 and $7 \mu \mathrm{~W}$ on AD7710.

The AD7710/AD7712 uses a second-order sigma-delta modulator and a digital filter that provides a rolling average of the sampled output. After power-up, or if there is a step change in the input voltage, there is a settling time that must elapse before valid data is obtained.

## Input Sample Rate

The modulator sample frequency for the device remains at $\mathrm{f}_{\mathrm{CLK} \mathrm{IN}} / 512\left(19.5 \mathrm{kHz} @ \mathrm{f}_{\mathrm{CLK} \text { IN }}=10 \mathrm{MHz}\right)$ regardless of the selected gain. However, gains greater than $\times 1$ are achieved by a combination of multiple input samples per modulator cycle and a scaling of the ratio of reference capacitor to input capacitor. As a result of the multiple sampling, the input sample rate of the device varies with the selected gain (see Table III). The effective input impedance is $1 / \mathrm{C} \cdot \mathrm{f}_{\mathrm{S}}$ where C is the input sampling capacitance and $f_{S}$ is the input sample rate.

Table III. Input Sampling Frequency vs. Gain

| Gain | Input Sampling Frequency ( $\mathrm{f}_{\mathbf{s}}$ ) |
| :---: | :---: |
| 1 | $\mathrm{f}_{\text {CLK IN }} / 512$ (19.5 kHz @ $\left.\mathrm{f}_{\text {CLK IN }}=10 \mathrm{MHz}\right)$ |
| 2 | $2 \times \mathrm{f}_{\text {CLK IN }} / 512$ (39 kHz @ $\left.\mathrm{f}_{\text {CLK IN }}=10 \mathrm{MHz}\right)$ |
| 4 | $4 \times \mathrm{f}_{\text {CLK IN }} / 512$ ( $78 \mathrm{kHz} @ \mathrm{f}_{\text {CLK IN }}=10 \mathrm{MHz}$ ) |
| 8 | $8 \times \mathrm{f}_{\text {CLK IN }} / 512\left(156 \mathrm{kHz} @ \mathrm{f}_{\text {CLK IN }}=10 \mathrm{MHz}\right)$ |
| 16 | $8 \times \mathrm{f}_{\text {CLK IN }} / 512\left(156 \mathrm{kHz} @ \mathrm{f}_{\text {CLK IN }}=10 \mathrm{MHz}\right)$ |
| 32 | $8 \times \mathrm{f}_{\text {CLK IN }} / 512\left(156 \mathrm{kHz} @ \mathrm{f}_{\text {CLK IN }}=10 \mathrm{MHz}\right)$ |
| 64 | $8 \times \mathrm{f}_{\text {CLK }} \mathrm{IN} / 512\left(156 \mathrm{kHz} @ \mathrm{f}_{\text {CLK IN }}=10 \mathrm{MHz}\right)$ |
| 128 | $8 \times \mathrm{f}_{\text {CLK IN }} / 512\left(156 \mathrm{kHz} @ \mathrm{f}_{\text {CLK IN }}=10 \mathrm{MHz}\right)$ |

## DIGITAL FILTERING

The part's digital filter behaves like a similar analog filter, with a few minor differences.
First, since digital filtering occurs after the A-to-D conversion process, it can remove noise injected during the conversion process. Analog filtering cannot do this.
On the other hand, analog filtering can remove noise superimposed on the analog signal before it reaches the ADC. Digital filtering cannot do this and noise peaks riding on signals near full-scale have the potential to saturate the analog modulator and digital filter, even though the average value of the signal is within limits. To alleviate this problem, the part has over-range headroom built into the sigma-delta modulator and digital filter which allows overrange excursions of $5 \%$ above the analog input range. If noise signals are larger than this, consideration should be given to analog input filtering, or to reducing the input channel voltage so that its full-scale is half that of the analog input channel full-scale. This will provide an overrange capability greater than $100 \%$ at the expense of reducing the dynamic range by 1 bit ( $50 \%$ ).

## Filter Characteristics

The cutoff frequency of the digital filter is determined by the value loaded to bits FS0 to FS11 in the control register. At the maximum clock frequency of 10 MHz , the minimum cutoff frequency of the filter is 2.58 Hz while the maximum programmable cutoff frequency is 269 Hz .
Figure 2 shows the filter frequency response for a cutoff frequency of 2.62 Hz which corresponds to a first filter notch frequency of 10 Hz . This is a $(\sin x / x)^{3}$ response (also called $\sin c^{3}$ ) that provides $>100 \mathrm{~dB}$ of 50 Hz and 60 Hz rejection. Programming a different cutoff frequency via FS0-FS11 does not alter the profile of the filter response, it changes the frequency of the notches as outlined in the Control Register section.


Figure 2. Frequency Response of AD7710/AD7712 Filter

Since the AD7710/AD7712 contains this on-chip, low-pass filtering, there is a settling time associated with step function inputs and data on the output will be invalid after a step change until the settling time has elapsed. The settling time depends upon the notch frequency chosen for the filter. The output data rate equates to this filter notch frequency and the settling time of the filter to a full-scale step input is 4 times the output data period. In applications using both input channels, the settling time of the filter must be allowed to elapse before data from the second channel is accessed.

## Post Filtering

The on-chip modulator provides samples at a 19.5 kHz output rate. The on-chip digital filter decimates these samples to provide data at an output rate which corresponds to the programmed first notch frequency of the filter. Since the output data rate exceeds the Nyquist criterion, the output rate for a given bandwidth will satisfy most application requirements. However, there may be some applications which require a higher data rate for a given bandwidth and noise performance. Applications which need this higher data rate will require some post filtering following the digital filter of the AD7710/AD7712.
For example, if the required bandwidth is 7.86 Hz but the required update rate is 100 Hz , the data can be taken from the AD7710/AD7712 at the 100 Hz rate giving a -3 dB bandwidth of 26.2 Hz . Post filtering can be applied to this to reduce the bandwidth and output noise, to the 7.86 Hz bandwidth level, while maintaining an output rate of 100 Hz .
Post filtering can also be used to reduce the output noise from the device for bandwidths below 2.62 Hz . At a gain of 128 , the output rms noise is 420 nV . This is essentially device noise or white noise, and since the input is chopped, the noise has a flat frequency response. By reducing the bandwidth below 2.62 Hz , the noise in the resultant passband can be reduced. A reduction in bandwidth by a factor of 2 results in a $\sqrt{2}$ reduction in the output rms noise. This additional filtering will result in a longer settling time.

## Antialias Considerations

The digital filter does not provide any rejection at integer multiples of the modulator sample frequency ( $\mathrm{n} \times 19.5 \mathrm{kHz}$, where n $=1,2,3 \ldots$ ). This means that there are frequency bands, $\pm f_{3}$ dB wide ( $f_{3}$ dB is cutoff frequency selected by FS0 to FS11) where noise passes unattenuated to the output. However, due to the AD7710/AD7712's high oversampling ratio, these bands occupy only a small fraction of the spectrum and most broadband noise is filtered. In any case, because of the high oversampling ratio a simple, RC, single pole filter is generally sufficient to attenuate the signals in these bands on the analog input and thus provide adequate antialiasing filtering.

## AD7710/AD7712

If passive components are placed in front of the differential inputs, care must be taken to ensure that the source impedance is low enough so as not to introduce gain errors in the system. The dc input impedance for the differential inputs is over $1 \mathrm{G} \Omega$. The input appears as a dynamic load which varies with the clock frequency and with the selected gain (see Figure 3). The input sample rate, as shown in Table III, determines the time allowed for the analog input capacitor, $\mathrm{C}_{\mathrm{IN}}$, to be charged. External impedances result in a longer charge time for this capacitor and this may result in gain errors being introduced on the analog inputs. Table IV shows the allowable external resistance/ capacitance values such that no gain error to the 16 -bit level is introduced while Table V shows the allowable external resistance/capacitance values such that no gain error to the 20-bit level is introduced. Both inputs of the differential input channels look into similar input circuitry.


Figure 3. Differential Inputs Impedance

Table IV. Typical External Series Resistance Which Will Not Introduce 16-Bit Gain Error

|  | External Capacitance (pF) |  |  |  |  |  |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Gain | $\mathbf{0}$ | $\mathbf{5 0}$ | $\mathbf{1 0 0}$ | $\mathbf{5 0 0}$ | $\mathbf{1 0 0 0}$ | $\mathbf{5 0 0 0}$ |
| 1 | $184 \mathrm{k} \Omega$ | $45.3 \mathrm{k} \Omega$ | $27.1 \mathrm{k} \Omega$ | $7.3 \mathrm{k} \Omega$ | $4.1 \mathrm{k} \boldsymbol{\Omega}$ | $1.1 \mathrm{k} \boldsymbol{\Omega}$ |
| 2 | $88.6 \mathrm{k} \Omega$ | $22.1 \mathrm{k} \Omega$ | $13.2 \mathrm{k} \Omega$ | $3.6 \mathrm{k} \Omega$ | $2.0 \mathrm{k} \Omega$ | $560 \Omega$ |
| 4 | $41.4 \mathrm{k} \Omega$ | $10.6 \mathrm{k} \Omega$ | $6.3 \mathrm{k} \Omega$ | $1.7 \mathrm{k} \Omega$ | $970 \Omega$ | $270 \Omega$ |
| $8-128$ | $17.6 \mathrm{k} \Omega$ | $4.8 \mathrm{k} \Omega$ | $2.9 \mathrm{k} \Omega$ | $790 \Omega$ | $440 \Omega$ | $120 \Omega$ |

Table V. Typical External Series Resistance Which Will Not Introduce 20-Bit Gain Error

|  | External Capacitance (pF) |  |  |  |  |  |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Gain | $\mathbf{0}$ | $\mathbf{5 0}$ | $\mathbf{1 0 0}$ | $\mathbf{5 0 0}$ | $\mathbf{1 0 0 0}$ | $\mathbf{5 0 0 0}$ |
| 1 | $145 \mathrm{k} \Omega$ | $34.5 \mathrm{k} \Omega$ | $20.4 \mathrm{k} \Omega$ | $5.2 \mathrm{k} \Omega$ | $2.8 \mathrm{k} \Omega$ | $700 \boldsymbol{\Omega}$ |
| 2 | $70.5 \mathrm{k} \Omega$ | $16.9 \mathrm{k} \Omega$ | $10 \mathrm{k} \Omega$ | $2.5 \mathrm{k} \Omega$ | $1.4 \mathrm{k} \Omega$ | $350 \Omega$ |
| 4 | $31.8 \mathrm{k} \Omega$ | $8.0 \mathrm{k} \Omega$ | $4.8 \mathrm{k} \Omega$ | $1.2 \mathrm{k} \Omega$ | $670 \Omega$ | $170 \Omega$ |
| $8-128$ | $13.4 \mathrm{k} \Omega$ | $3.6 \mathrm{k} \Omega$ | $2.2 \mathrm{k} \Omega$ | $550 \Omega$ | $300 \Omega$ | $80 \Omega$ |

The numbers in the above tables assume a full-scale change on the analog input. In any case, the error introduced due to longer charging times is a gain error which can be removed using the system calibration capabilities of the AD7710/AD7712 provided that the resultant span is within the span limits of the system calibration techniques for the AD7710/AD7712.
The AIN2 input of the AD7712 contains a resistive attenuation network as outlined in Figure 4. The typical input impedance on this input is $44 \mathrm{k} \Omega$. As a result, the AIN2 input of the AD7712 should be driven from a low impedance source.


Figure 4. AIN2 of AD7712 Input Impedance

## ANALOG INPUT FUNCTIONS

## Analog Input Ranges

The analog inputs on the AD7710/AD7712 provide the user with considerable flexibility in terms of analog input voltage ranges. One of the inputs is a differential, programmable gain, input channel which can handle either unipolar or bipolar input signals. The common mode range of this input is from $\mathrm{V}_{\mathrm{SS}}$ to $A V_{D D}$ provided that the absolute value of the analog input voltage lies between $V_{S S}-30 \mathrm{mV}$ and $\mathrm{AV}_{\mathrm{DD}}+30 \mathrm{mV}$. The second analog input is a single-ended, programmable gain high level input which accepts analog input ranges of 0 to $+4 \times \mathrm{V}_{\mathrm{REF}} /$ GAIN or $\pm 4 \times \mathrm{V}_{\mathrm{REF}} /$ GAIN.
The dc input leakage current on the AIN1 input is 10 pA maximum at $25^{\circ} \mathrm{C}( \pm 1 \mathrm{nA}$ over temperature $)$. This results in a dc offset voltage developed across the source impedance. However, this dc offset effect can be compensated for by a combination of the differential input capability of the part and its system calibration mode. The dc input current on the AIN2 input depends on the input voltage, For the nominal input voltage range of $\pm 10 \mathrm{~V}$, the input current is $\pm 225 \mu \mathrm{~A}$ typ.

## Burn-Out Current

The AIN1(+) input of the AD7710/AD7712 contains a $1 \mu \mathrm{~A}$ current source which can be turned on/off via the control register. This current source can be used in checking that a transducer has not burnt-out or gone open circuit before attempting to take measurements on that channel. If the current is turned on and is allowed flow into the transducer and a measurement of the input voltage on the AIN1 input is taken, it can indicate that the transducer is not functioning correctly. For normal operation, this burn-out current is turned off by writing a 0 to the BO bit in the control register.

## Bipolar/Unipolar Inputs

The two analog inputs on the AD7710/AD7712 can accept either unipolar or bipolar input voltage ranges. Bipolar or unipolar options are chosen by programming the $\mathrm{B} / \mathrm{U}$ bit of the control register. This programs both channels for either unipolar or bipolar operation. Programming the part for either unipolar or bipolar operation does not change any of the input signal conditioning; it simply changes the data output coding. The data coding is binary for unipolar inputs and offset binary for bipolar inputs.
Both analog inputs on the AD7710 and the AIN1 input channel of the AD7712 are differential and, as a result, the voltage to which the unipolar and bipolar signals are referenced is the voltage on the $\operatorname{AIN}(-)$ input. For example, if $\operatorname{AIN}(-)$ is +1.25 V and the part is configured for unipolar operation with a gain of 1 and a $\mathrm{V}_{\mathrm{REF}}$ of +2.5 V , the input voltage range on the $\operatorname{AIN}(+$ ) input is +1.25 V to +3.75 V . If $\operatorname{AIN}(-)$ is +1.25 V and the part is configured for bipolar mode with a gain of 1 and a $\mathrm{V}_{\text {REF }}$ of +2.5 V , the analog input range on the AIN(+) input is -1.25 V to +3.75 V . For the AIN2 input of the AD7712, the input signals are referenced to AGND.

## REFERENCE INPUT/OUTPUT

The AD7710/AD7712 contains a temperature compensated +2.5 V reference which has an initial tolerance of $\pm 4 \%$. This reference voltage is provided at the REF OUT pin and it can be used as the reference voltage for the part by connecting the REF OUT pin to the REF IN $(+)$ pin. This REF OUT pin is a single-ended output, referenced to AGND, which is capable of providing up to 1 mA to an external load. In applications where REF OUT is connected directly to REF IN(+), REF IN( - ) should be tied to AGND to provide the nominal +2.5 V reference for the AD7710/AD7712.
The reference inputs of the AD7710/AD7712, REF IN(+) and REF IN(-), provide a differential reference input capability. The common mode range for these differential inputs is from $\mathrm{V}_{\mathrm{SS}}$ to $\mathrm{AV}_{\mathrm{DD}}$. The nominal differential voltage, $\mathrm{V}_{\mathrm{REF}}$ (REF IN $(+)-$ REF IN( - )), is +2.5 V for specified operation, but the reference voltage can go to +5 V with no degradation in performance provided that the absolute value of REF IN( + ) and REF IN $(-)$ does not exceed its $A V_{D D}$ and $V_{\text {Ss }}$ limits and the $\mathrm{V}_{\text {BIAS }}$ input voltage range limits are obeyed. The part is also functional with $\mathrm{V}_{\text {REF }}$ voltages down to 1 V but with degraded performance as the output noise will, in terms of LSB size, be larger. REF IN $(+)$ must always be greater than REF IN $(-)$ for correct operation of the AD7710/AD7712.
Both reference inputs provide a high impedance, dynamic load similar to the AIN1 analog input. The maximum dc input leakage current is $10 \mathrm{pA}( \pm 1 \mathrm{nA}$ over temperature) and source resistance may result in gain errors on the part. The reference inputs look like the AIN1 analog input (see Figure 7). In this case, $\mathrm{R}_{\mathrm{INT}}$ is $5 \mathrm{k} \Omega$ typ and $\mathrm{C}_{\mathrm{INT}}$ varies with gain. The input sample rate is $\mathrm{f}_{\mathrm{CLK}} \mathrm{IN} / 512$ and does not vary with gain. For gains of 1 to $8 \mathrm{C}_{\mathrm{INT}}$ is 20 pF ; for a gain of 16 it is 10 pF ; for a gain of 32 it is 5 pF ; for a gain of 64 it is 2.5 pF , and for a gain of 128 it is 1.25 pF .
The digital filter of the part removes noise from the reference input just as it does with the analog input, and the same limitations apply regarding lack of noise rejection at integer multiples of the sampling frequency. The output noise performance outlined in Tables I and II assumes a clean reference. If the reference noise in the bandwidth of interest is excessive, it can degrade the performance of the AD7710/AD7712. Using the on-chip reference as the reference source for the part (i.e., connecting REF OUT to REF IN) results in somewhat degraded output noise performance from the AD7710/AD7712 for portions of the noise table that are dominated by the device noise. The on-chip reference noise effect is eliminated in ratiometric applications where the reference is used to provide its excitation voltage for the analog front end. Recommended reference voltage sources for the AD7710/AD7712 include the AD780 and AD680 2.5 V references.
$\mathbf{V}_{\text {bias }}$ Input
The $\mathrm{V}_{\text {bias }}$ input determines at what voltage the internal analog circuitry is biased. It essentially provides the return path for analog currents flowing in the modulator and, as such, it should be driven from a low impedance point to minimize errors.
For maximum internal headroom, the $\mathrm{V}_{\text {bias }}$ voltage should be set halfway between $A V_{D D}$ and $V_{\text {ss }}$. The difference between $A V_{\text {DD }}$ and $\left(\mathrm{V}_{\text {BIAS }}+0.85 \times \mathrm{V}_{\text {REF }}\right)$ determines the amount of headroom which the circuit has at the upper end while the difference between $\mathrm{V}_{\mathrm{Ss}}$ and ( $\mathrm{V}_{\text {BIAS }}-0.85 \times \mathrm{V}_{\mathrm{REF}}$ ) determines the amount of headroom the circuit has at the lower end. Care should be taken in choosing a $\mathrm{V}_{\text {BIAs }}$ voltage to ensure that is stays within prescribed limits. For single +5 V operation, the selected $\mathrm{V}_{\text {BIAS }}$ voltage must ensure that $\mathrm{V}_{\text {BIAS }} \pm 0.85 \times \mathrm{V}_{\mathrm{REF}}$ does not exceed $A V_{D D}$ or $V_{S S}$ or that the $V_{\text {bias }}$ voltage itself is greater than $\mathrm{V}_{\mathrm{ss}}+2.1 \mathrm{~V}$ and less than $\mathrm{AV}_{\mathrm{DD}}-2.1 \mathrm{~V}$. For single +10 V operation or dual $\pm 5 \mathrm{~V}$ operation, the selected $\mathrm{V}_{\text {BIAS }}$ voltage must ensure that $\mathrm{V}_{\text {BIAS }} \pm 0.85 \times \mathrm{V}_{\text {REF }}$ does not exceed $A V_{D D}$ or $V_{S S}$ or that the $V_{\text {BIAS }}$ voltage itself is greater than $V_{S S}+3 \mathrm{~V}$ or less than $A V_{D D}-3 \mathrm{~V}$. For example, with $A V_{\mathrm{DD}}=+4.75 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{REF}}=+2.5 \mathrm{~V}$, the allowable range for the $\mathrm{V}_{\text {BIAS }}$ voltage is +2.125 V to +2.625 V . With $\mathrm{AV}_{\mathrm{DD}}=+9.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{REF}}=+5 \mathrm{~V}$, the range for $\mathrm{V}_{\text {BIAS }}$ is +4.25 V to +5.25 V . With $\mathrm{AV}_{\mathrm{DD}}=+4.75 \mathrm{~V}$, $\mathrm{V}_{\mathrm{SS}}=-4.75 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{REF}}=+2.5 \mathrm{~V}$, the $\mathrm{V}_{\text {BIAS }}$ range is -2.625 V to +2.625 V .
The $V_{\text {bias }}$ voltage does have an effect on the $A V_{\text {DD }}$ power supply rejection performance of the AD7710/AD7712. If the $\mathrm{V}_{\text {BIAs }}$ voltage tracks the $A V_{D D}$ supply, it improves the power supply rejection from the $A V_{D D}$ supply line from 80 dB to 95 dB . Using an external Zener diode, connected between the $\mathrm{AV}_{\mathrm{DD}}$ line and $\mathrm{V}_{\text {BIAS }}$, as the source for the $\mathrm{V}_{\text {BIAS }}$ voltage gives the improvement in $\mathrm{AV}_{\mathrm{DD}}$ power supply rejection performance.

## USING THE AD7710/AD7712: SYSTEM DESIGN CONSIDERATIONS

The AD7710/AD7712 operates differently from successive approximation ADCs or integrating ADCs. Since it samples the signal continuously, like a tracking ADC, there is no need for a start convert command. The output register is updated at a rate determined by the first notch of the filter and the output can be read at any time, either synchronously or asynchronously.

## Clocking

The AD7710/AD7712 requires a master clock input, which may be an external TTL/CMOS compatible clock signal applied to the MCLK IN pin with the MCLK OUT pin left unconnected. Alternatively, a crystal of the correct frequency can be connected between MCLK IN and MCLK OUT, in which case the clock circuit will function as a crystal controlled oscillator. For lower clock frequencies, a ceramic resonator may be used instead of the crystal. For these lower frequency oscillators, external capacitors may be required on either the ceramic resonator or on the crystal.

The input sampling frequency, the modulator sampling frequency, the -3 dB frequency, output update rate and calibration time are all directly related to the master clock frequency, $\mathrm{f}_{\mathrm{CLK} \text { IN }}$. Reducing the master clock frequency by a factor of 2 will halve the above frequencies and update rate and will double the calibration time.
The current drawn from the $\mathrm{DV}_{\mathrm{DD}}$ power supply is also directly related to $f_{\text {CLK IN }}$. Reducing $f_{\text {CLK IN }}$ by a factor of 2 will halve the $\mathrm{DV}_{\mathrm{DD}}$ current but will not affect the current drawn from the $A V_{D D}$ power supply.

## System Synchronization

If multiple AD7710/AD7712s are operated from a common master clock, they can be synchronized to update their output registers simultaneously. A falling edge on the SYNC input resets the filter and places the AD7710/AD7712 into a consistent, known state. A common signal to the AD7710/AD7712s' SYNC inputs will synchronize their operation. This would normally be done after each AD7710/AD7712 has performed its own calibration or has had calibration coefficients loaded to it.
The SYNC input can also be used to reset the digital filter in systems where the turn-on time of the digital power supply ( $\mathrm{DV}_{\mathrm{DD}}$ ) is very long. In such cases, the AD7710/AD7712 will start operating internally before the $\mathrm{DV}_{\mathrm{DD}}$ line has reached its minimum operating level, +4.75 V . With a low $\mathrm{DV}_{\mathrm{DD}}$ voltage, the AD7710/AD7712's internal digital filter logic does not operate correctly. Thus, the AD7710/AD7712 may have clocked itself into an incorrect operating condition by the time that $\mathrm{DV}_{\mathrm{DD}}$ has reached its correct level. The digital filter will be reset upon issue of a calibration command (whether it is selfcalibration, system calibration or background calibration) to the AD7710/AD7712. This ensures correct operation of the AD7710/AD7712. In systems where the power-on default conditions of the AD7710/AD7712 are acceptable, and no calibration is performed after power-on, issuing a SYNC pulse to the AD7710/AD7712 will reset the AD7710/AD7712's digital filter logic. An R, C on the SYNC line, with R, C time constant longer than the $\mathrm{DV}_{\mathrm{DD}}$ power-on time, will perform the $\overline{\text { SYNC }}$ function.

## Accuracy

Sigma-Delta ADCs, like VFCs and other integrating ADCs, do not contain any source of nonmonotonicity and inherently offer no missing codes performance. The AD7710/AD7712 achieves excellent linearity by the use of high quality, on-chip silicon dioxide capacitors, which have a very low capacitance/voltage coefficient. The device also achieves low input drift through the use of chopper stabilized techniques in its input stage. To ensure excellent performance over time and temperature, the AD7710/AD7712 uses digital calibration techniques that minimize offset and gain error.

## Autocalibration

Autocalibration on the AD7710/AD7712 removes offset and gain errors from the device. A calibration routine should be initiated on the device whenever there is a change in the ambient operating temperature or supply voltage. It should also be initiated if there is a change in the selected gain, filter notch or bipolar/ unipolar input range. However, if the AD7710/AD7712 is in its background calibration mode, the above changes are all automatically taken care of (after the settling time of the filter has been allowed for).

The AD7710/AD7712 offers self-calibration, system calibration and background calibration facilities. For calibration to occur on the selected channel, the on-chip microcontroller must record the modulator output for two different input conditions. These are "zero scale" and "full-scale" points. With these readings, the microcontroller can calculate the gain slope for the input to output transfer function of the converter. Internally, the part works with a resolution of 33 bits to determine its conversion result of either 16 bits or 24 bits.
The AD7710/AD7712 also provides the facility to write to the on-chip calibration registers and in this manner the span and offset for the part can be adjusted by the user. The offset calibration register contains a value which is subtracted from all conversion results, while the full-scale calibration register contains a value which is multiplied by all conversion results. The offset calibration coefficient is subtracted from the result prior to the multiplication by the full-scale coefficient. In the first three modes outlined here, the $\overline{\text { DRDY }}$ indicates that calibration is complete by going low. If $\overline{\mathrm{DRDY}}$ is low before (or goes low during) the calibration command, it may take up to one modulator cycle before $\overline{\mathrm{DRDY}}$ goes high to indicate that calibration is in progress. Therefore, the $\overline{\text { DRDY }}$ line should be ignored for up to one modulator cycle after the last bit of the calibration command is written to the control register.

## Self-Calibration

In the self-calibration mode with a unipolar input range, the zero scale point used in determining the calibration coefficients is with both inputs shorted (i.e., $\operatorname{AIN}(+)=\operatorname{AIN}(-)=\mathrm{V}_{\text {BIAS }}$ for differential inputs and AIN $=\mathrm{V}_{\text {BIAS }}$ for single-ended inputs) and the full-scale point is $\mathrm{V}_{\text {REF }}$. The zero scale coefficient is determined by converting an internal shorted inputs node. The full scale coefficient is determined from the span between this shorted inputs conversion and a conversion on an internal $\mathrm{V}_{\mathrm{REF}}$ node. The self-calibration mode is invoked by writing the appropriate values $(0,0,1)$ to the MD2, MD1 and MD0 bits of the control register. In this calibration mode, the shorted inputs node is switched in to the modulator first and a conversion is performed; the $\mathrm{V}_{\text {REF }}$ node is then switched in and another conversion is performed. When the calibration sequence is complete, the calibration coefficients updated and the filter resettled to the analog input voltage, the $\overline{\mathrm{DRDY}}$ output goes low. The self-calibration procedure takes into account the selected gain on the PGA.
For bipolar input ranges in the self-calibrating mode, the sequence is very similar to that just outlined. In this case, the two points which the AD7710/AD7712 calibrates are midscale (bipolar zero) and positive full-scale.

## System Calibration

System calibration allows the AD7710/AD7712 to compensate for system gain and offset errors as well as its own internal errors. System calibration performs the same slope factor calculations as self-calibration but uses voltage values presented by the system to the AIN inputs for the zero and full-scale points. System calibration is a two-step process. The zero scale point must be presented to the converter first. It must be applied to the converter before the calibration step is initiated and remain stable until the step is complete. System calibration is initiated by writing the appropriate values ( $0,1,0$ ) to the MD2, MD1 and MD0 bits of the control register. The $\overline{\mathrm{DRDY}}$ output from the device will signal when the step is complete by going low. After the zero scale point is calibrated, the full-scale point is applied and the second step of the calibration process is initiated by again writing the appropriate values $(0,1,1)$ to MD2, MD1 and MD0. Again the full-scale voltage must be set up before the calibration is initiated and it must remain stable throughout the calibration step. $\overline{\text { DRDY }}$ goes low at the end of this second step to indicate that the system calibration is complete. In the unipolar mode, the system calibration is performed between the two endpoints of the transfer function; in the bipolar mode, it is performed between midscale and positive full scale.
This two-step system calibration mode offers another feature. After the sequence has been completed, additional offset or gain calibrations can be performed by themselves to adjust the zero reference point or the system gain. This is achieved by performing the first step of the system calibration sequence (by writing $0,1,0$ to MD2, MD1, MD0). This will adjust the zero scale or offset point but will not change the slope factor from what was set during a full system calibration sequence.
System calibration can also be used to remove any errors from an antialiasing filter on the analog input. A simple $\mathrm{R}, \mathrm{C}$ antialiasing filter on the front end may introduce a gain error on the analog input voltage but the system calibration can be used to remove this error.

## System Offset Calibration

System offset calibration is a variation of both the system calibration and self-calibration. In this case, the zero scale point for the system is presented to the AIN input of the converter. System offset calibration is initiated by writing $1,0,0$ to MD2, MD1, MD0. The system zero scale coefficient is determined by converting the voltage applied to the AIN input, while the fullscale coefficient is determined from the span between this AIN conversion and a conversion on $\mathrm{V}_{\text {ReF }}$. The zero scale point should be applied to the AIN input for the duration of the calibration sequence. This is a one step calibration sequence with $\overline{\mathrm{DRDY}}$ going low when the sequence is completed. In the unipolar mode, the system offset calibration is performed between the two endpoints of the transfer function; in the bipolar mode, it is performed between midscale and positive full scale.

## Background Calibration

The AD7710/AD7712 also offers a background calibration mode where the part interleaves its calibration procedure with its normal conversion sequence. In the background calibration mode, the same voltages are used as the calibration points as are used in the self-calibration mode, i.e., shorted inputs and $\mathrm{V}_{\mathrm{REF}}$. The background calibration mode is invoked by writing $1,0,1$ to MD2, MD1, MD0 of the control register. When invoked, the background calibration mode reduces the output data rate of the

## AD7710/AD7712

AD7710/AD7712 by a factor of six while the -3 dB bandwidth remains unchanged. Its advantage is that the part is continually performing calibration and automatically updating its calibration coefficients. As a result, the effects of temperature drift, supply sensitivity and time drift on zero and full scale errors are automatically removed. When the background calibration mode is turned on, the part will remain in this mode until bits MD2, MD1 and MD0 of the control register are changed. With background calibration mode on, the first result from the AD7710/

AD7712 will be incorrect as the full-scale calibration will not have been performed. For a step change on the input, the second output update will have settled to $100 \%$ of the final value.

Table VI summarizes the calibration modes and the calibration points associated with them. It also gives the duration from when the calibration is invoked to when valid data is available to the user.

Table VI. Calibration Truth Table

| Cal Type | MD2, MD1, MD0 | Zero Scale Cal | Full-Scale Cal | Sequence | Duration |
| :--- | :--- | :--- | :--- | :--- | :--- |
| Self-Cal | $0,0,1$ | Shorted Inputs | $\mathrm{V}_{\text {REF }}$ | One Step | $9 \times 1 /$ Output Rate |
| System Cal | $0,1,0$ | AIN | - | Two Step | $4 \times$ 1/Output Rate |
| System Cal | $0,1,1$ | - | AIN | Two Step | $4 \times$ 1/Output Rate |
| System Offset Cal | $1,0,0$ | AIN | V $_{\text {REF }}$ | One Step | $9 \times$ 1/Output Rate |
| Background Cal | $1,0,1$ | Shorted Inputs | $\mathrm{V}_{\text {REF }}$ | One Step | $6 \times 1 /$ Output Rate |

## Span and Offset Limits

Whenever a system calibration mode is used, there are limits on the amount of offset and span that can be accommodated. The range of input span in both the unipolar and bipolar modes for both inputs on the AD7710 and AIN1 of the AD7712 has a minimum value of $0.8 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}$ and a maximum value of $2.1 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}$. For AIN2 on the AD7712, both numbers are a factor of 4 higher.
The amount of offset that can be accommodated depends on whether the unipolar or bipolar mode is being used. This offset range is limited by the requirement that the positive fullscale calibration limit is $\leq 1.05 \times \mathrm{V}_{\text {REF }} /$ GAIN for the differential inputs. Therefore, the offset range plus the span range cannot exceed $1.05 \times \mathrm{V}_{\text {REF }} /$ GAIN for the differential inputs. If the span is at its minimum ( $0.8 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}$ ) the maximum the offset can be is $\left(0.25 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}\right)$ for the differential inputs. For AIN2 of AD7712, both ranges are multiplied by a factor of 4 .
In the bipolar mode, the system offset calibration range is again restricted by the span range. The span range of the converter in bipolar mode is equidistant around the voltage used for the zero scale point thus the offset range plus half the span range cannot exceed ( $1.05 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}$ ) for the differential inputs. If the span is set to $2 \times \mathrm{V}_{\mathrm{REF}} /$ GAIN, the offset span cannot move more than $\pm\left(0.05 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}\right)$ before the endpoints of the transfer function exceed the input overrange limits $\pm(1.05 \times$ $\mathrm{V}_{\text {REF }}$ /GAIN) for the differential inputs. If the span range is set to the minimum $\pm\left(0.4 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}\right)$ the maximum allowable offset range is $\pm\left(0.65 \times \mathrm{V}_{\mathrm{REF}} /\right.$ GAIN $)$ for the differential inputs. Once again, for AIN2 of AD7712, both ranges are multiplied by a factor of 4.

## POWER-UP AND CALIBRATION

On power-up, the AD7710/AD7712 performs an internal reset which sets the contents of the control register to a known state. However, to ensure correct calibration for the device a calibration routine should be performed after power-up.
The power dissipation and temperature drift of the AD7710/ AD7712 are low and no warm-up time is required before the initial calibration is performed. However, if an external reference is being used, this reference must have stabilized before calibration is initiated.

## Drift Considerations

The AD7710/AD7712 uses chopper stabilization techniques to minimize input offset drift. Charge injection in the analog switches and dc leakage currents at the sampling node are the primary sources of offset voltage drift in the converter. The dc input leakage current is essentially independent of the selected gain. Gain drift within the converter depends primarily upon the temperature tracking of the internal capacitors. It is not affected by leakage currents.

Measurement errors due to offset drift or gain drift can be eliminated at any time by recalibrating the converter or by operating the part in the background calibration mode. Using the system calibration mode can also minimize offset and gain errors in the signal conditioning circuitry. Integral and differential linearity errors are not significantly affected by temperature changes.

## POWER SUPPLIES AND GROUNDING

Since the analog inputs and reference input are differential, most of the voltages in the analog modulator are common-mode voltages. $\mathrm{V}_{\text {BIAS }}$ provides the return path for most of the analog currents flowing in the analog modulator. As a result, the $\mathrm{V}_{\text {BIAS }}$ input should be driven from a low impedance to minimize errors due to charging/discharging impedances on this line. When the internal reference is used as the reference source for the part, AGND is the ground return for this reference voltage.
The analog and digital supplies to the AD7710/AD7712 are independent and separately pinned out to minimize coupling between the analog and digital sections of the device. The digital filter will provide rejection of broadband noise on the power supplies, except at integer multiples of the modulator sampling frequency. The digital supply ( $\mathrm{DV}_{\mathrm{DD}}$ ) must never exceed the analog positive supply $\left(\mathrm{AV}_{\mathrm{DD}}\right)$ by more than 0.3 V . Power supply sequencing therefore is important. If separate analog and digital supplies are used, care must be taken to ensure that the analog supply is powered up first. If this cannot be ensured or if $D V_{D D}$ can exceed $A V_{D D}$ at any other time, the protection scheme outlined in Figure 5 is recommended to protect the device. In systems where $A V_{D D}=+5 \mathrm{~V}$ and $\mathrm{DV}_{\mathrm{DD}}=+5 \mathrm{~V}$, it is recommended that $A V_{D D}$ and $D V_{D D}$ are driven from the same +5 V supply, although each supply should be decoupled separately. It is preferable that the common supply is the system's analog +5 V supply.

It is also important that power is applied to the AD7710/ AD7712 before signals at REF IN, AIN or the logic input pins in order to avoid latch-up. If separate supplies are used for the AD7710/AD7712 and the system digital circuitry, then the AD7710/AD7712 should be powered up first. If it is not possible to guarantee this, then current limiting resistors should be placed in series with the logic inputs.

*THIS DIODE MAY BE NECESSARY IF THE SHORT-CIRCUIT CURRENT FROM THE DIGITAL SUPPLY IS TOO LARGE FOR THE SD103C.

Figure 5. Protection Scheme for $D V_{D D}$ Powering-Up Before $A V_{D D}$

## DIGITAL INTERFACE

The AD7710/AD7712's serial communications port provides a flexible arrangement to allow easy interfacing to industry standard microprocessors, microcontrollers and digital signal processors. A serial read to the part can access data from the output register, the control register or from the calibration registers. A serial write to the part can write data to the control register or the calibration registers.
Two different modes of operation are available, optimized for different types of interface where the AD7710/AD7712 can act either as master in the system (it provides the serial clock) or as slave (an external serial clock can be provided to the AD7710/ AD7712). These two modes, labelled self-clocking mode and external clocking mode, are discussed in detail in the following sections.

## Self-Clocking Mode

The part is configured for its self-clocking mode by tying the MODE pin high. In this mode, the part provides the serial clock signal used for the transfer of data to and from the AD7710/AD7712. This self-clocking mode can be used with processors that allow an external device to clock their serial port including most digital signal processors and microcontrollers such as the 68 HCl 1 and 68 HC 05 . It also allows easy interfacing to serial parallel conversion circuits in systems with parallel data communication, allowing interfacing to 74XX299 Universal Shift registers without any additional decoding. In the case of shift registers, the serial clock line should have a pull-down resistor instead of the pull-up resistor shown in Figure 6 and Figure 7.

## Read Operation

Data can be read from either the output register, the control register or the calibration registers. A0 determines whether the data read accesses data from the control register or from the output/calibration registers. This A0 signal must remain valid for the duration of the serial read operation. With A0 high, data is accessed from either the output register or from the calibra-
tion registers. With A0 low, data is accessed from the control register.
The function of the $\overline{\text { DRDY }}$ line is dependent only on the output update rate of the device and the reading of the output data register. $\overline{\mathrm{DRDY}}$ goes low when a new data word is available in the output data register. It is reset high when the last bit of data (either 16th bit or 24th bit) is read from the output register. If data is not read from the output register, the $\overline{\mathrm{DRDY}}$ line will remain low. The output register will continue to be updated at the output update rate but $\overline{\mathrm{DRDY}}$ will not indicate this. A read from the device in this circumstance will access the most recent word in the output register. If a new data word becomes available to the output register while data is being readofrom the output register, $\overline{\mathrm{DRDY}}$ will not indicate this and the new data word will be lost to the user. $\overline{\text { DRDY }}$ is not affected by reading from the control register or the calibration registers.
Data can only be accessed from the output data register when $\overline{\mathrm{DRDY}}$ is low. If $\overline{\mathrm{RFS}}$ goes low with $\overline{\mathrm{DRDY}}$ high, no data transfer will take place. $\overline{\text { DRDY }}$ does not have any effect on reading data from the control register or from the calibration registers.
Figures $6 a$ and $6 b$ show timing diagrams for reading from the part in the self-clocking mode. Figure 6a shows a situation where all the data is read from the part in one read operation. Figure 6 b shows a situation where the data is read from the AD7710/AD7712 over a number of read operations. Both read operations show a read from the part's output data register. A read from the control register or calibration registers is similar but in these cases the $\overline{\mathrm{DRDY}}$ line is not related to the read function. Depending on the output update rate, it can go low at any stage in the control/calibration register read cycle without affecting the read and its status should be ignored. A read operation from either the control or calibration registers must always read 24 bits of data from the respective register.
Figure 6a shows a read operation from the part where $\overline{\mathrm{RFS}}$ remains low for the duration of the data word transmission. For the timing diagram shown, it is assumed that there is a pull-up resistor on the SCLK output. With $\overline{\text { DRDY }}$ low, the $\overline{\text { RFS }}$ input is brought low. $\overline{\mathrm{RFS}}$ going low enables the serial clock of the AD7710/AD7712 and also places the MSB of the word on the serial data line. All subsequent data bits are clocked out on a high to low transition of the serial clock and are valid prior to the following rising edge of this clock. The final active falling :, edge of SCLK clocks out the LSB and this LSB is valid prior to the final active rising edge of SCLK. Coincident with the next falling edge of SCLK, $\overline{\text { DRDY }}$ is reset high. $\overline{\text { DRDY }}$ going high turns off the SCLK and the SDATA outputs. This means that the data hold time for the LSB is slightly shorter than for all other bits.
Figure 6 b shows a timing diagram for a read operation where $\overline{\text { RFS }}$ returns high during the transmission of the word and returns low again to access the rest of the data word. As before, the waveform for SCLK assumes that there is a pull-up resistor on this line. Timing parameters and functions are very similar to that outlined for Figure 6a, but Figure 6b has a number of additional times to show timing relationships when $\overline{\mathrm{RFS}}$ returns high in the middle of transferring a word.
$\overline{\mathrm{RFS}}$ should return high during a low time of SCLK. On the rising edge of $\overline{\mathrm{RFS}}$, the SCLK and SDATA outputs are turned


Figure 6a. Self-Clocking Mode, Output Data Read Operation


Figure 6b. Self-Clocking Mode, Output Data Read Operation ( $\overline{\operatorname{RFS}}$ Returns High During Read Operation)
off. $\overline{\text { DRDY }}$ remains low and will remain low until all bits of the data word are read from the part, regardless of the number of times $\overline{\mathrm{RFS}}$ changes state during the read operation. Depending on the time between the falling edge of SCLK and the rising edge of $\overline{\mathrm{RFS}}$, the next bit (BIT N + 1) may appear on the databus before $\overline{\mathrm{RFS}}$ goes high. When $\overline{\mathrm{RFS}}$ returns low again, it turns on the SCLK output and activates the SDATA output. When the entire word is transmitted, the $\overline{\mathrm{DRDY}}$ line will go high turning off the SDATA and SCLK lines as per Figure 6a.

## Write Operation

Data can be written to either the control register or calibration registers. In either case, the write operation is not affected by the $\overline{\mathrm{DRDY}}$ line and the write operation does not have any effect on the status of DRDY. A write operation to the control register or the calibration register must always write 24 bits to the respective register.
Figure 7a shows a write operation to the AD7710/AD7712 with TFS remaining low for the duration of the write operation. A0 determines whether a write operation transfers data to the control register or to the calibration registers. This A0 signal must remain valid for the duration of the serial write operation. The falling edge of $\overline{\mathrm{TFS}}$ enables the internally generated SCLK output. The serial data to be loaded to the AD7710/AD77.12 must
be valid on the rising edge of this SCLK signal. Data is clocked into the AD7710/AD7712 on the rising edge of the SCLK signal with the MSB transferred first. On the last active high time of SCLK, the LSB is loaded to the AD7710/AD7712. Subsequent to the next falling edge of SCLK, the SCLK output is turned off. (The timing diagram of Figure 7a assumes a pull-up resistor on the SCLK line.)
Figure 7 b shows a timing diagram for a write operation to the AD7710/AD7712 with TFS returning high during the write operation and returning low again to write the rest of the data word. Once again, the timing diagram of Figure 7b assumes a pull-up resistor on the SCLK output. Timing parameters and functions are very similar to that outlined for Figure 7a but Figure 7 b has a number of additional times to show timing relationships when TFS returns high in the middle of transferring a word.
The falling edge of TFS again initiates the SCLK output and data to be loaded to the AD7710/AD7712 must be valid prior to the rising edge of this SCLK signal. The rising edge of TFS turns off the SCLK output. TFS should return high during the low time of SCLK. When TFS returns low again, it turns on the SCLK output. When all data bits have been written to the device, the SCLK output is turned off as per Figure 7a.


Figure 7a. Self-Clocking Mode, Control/Calibration Register Write Operation


Figure 7b. Self-Clocking Mode, Control/Calibration Register Write Operation ( $\overline{T F S}$ Returns High During Write Operation)

## External Clocking Mode

The AD7710/AD7712 is configured for its external clocking mode by tying the MODE pin low. In this mode, SCLK of the part is configured as an input and an external serial clock must be provided to this SCLK pin. This external clocking mode is designed for direct interface to systems which provide a serial clock output that is synchronized to the serial data output, including microcontrollers such as the $80 \mathrm{C} 51,87 \mathrm{C} 51,68 \mathrm{HCl1}$ and 68 HC 05 and most digital signal processors.

## Read Operation

As with the self-clocking mode, data can be read from either the output register, the control register or the calibration registers. A0 determines whether the data read accesses data from the control register or from the output/calibration registers. This A0 signal must remain valid for the duration of the serial read operation. With A0 high, data is accessed from either the output register or from the calibration registers. With A0 low, data is accessed from the control register.
The function of the $\overline{\mathrm{DRDY}}$ line is dependent only on the output update rate of the device and the reading of the output data register. $\overline{\mathrm{DRDY}}$ goes low when a new data word is available in the output data register. It is reset high when the last bit of data (either 16th bit or 24th bit) is read from the output register. If data is not read from the output register, the $\overline{\mathrm{DRDY}}$ line will
remain low. The output register will continue to be updated at the output update rate but $\overline{\text { DRDY }}$ will not indicate this. A read from the device in this circumstance will access the most recent word in the output register. If a new data word becomes available to the output register while data is being read from the output register, $\overline{\text { DRDY }}$ will not indicate this and the new data word will be lost to the user. $\overline{\text { DRDY }}$ is not affected by reading from the control register or the calibration register.

Data can only be accessed from the output data register when $\overline{\mathrm{DRDY}}$ is low. If $\overline{\mathrm{RFS}}$ goes low while $\overline{\mathrm{DRDY}}$ is high, no data transfer will take place. $\overline{\text { DRDY }}$ does not have any effect on reading data from the control register or from the calibration registers.
Figures 8 a and 8 b show timing diagrams for reading from the part's in the external clocking mode. Figure 8a shows a situation where all the data is read from the part in one read operation. Figure 8 b shows a situation where the data is read from the part over a number of read operations. Both read operations show a read from the part's output data register. A read from the control register or calibration registers is similar but in these cases the $\overline{\text { DRDY }}$ line is not related to the read function. Depending on the output update rate, it can go low at any stage in the control/calibration register read cycle without affecting the read and its status should be ignored. A read operation from either the control or calibration registers must always read 24 bits of data from the respective register.

## AD7710/AD7712

Figure 8a shows a read operation from the AD7710/AD7712 where $\overline{\mathrm{RFS}}$ remains low for the duration of the data word transmission. With $\overline{\mathrm{DRDY}}$ low, the $\overline{\mathrm{RFS}}$ input is brought low. The input SCLK signal should be low between read and write operations. $\overline{\mathrm{RFS}}$ going low places the MSB of the word to be read on the serial data line. All subsequent data bits are clocked out on a high to low transition of the serial clock and are valid prior to the following rising edge of this clock. The penultimate falling edge of SCLK clocks out the LSB and the final falling edge resets the $\overline{\text { DRDY }}$ line high. This rising edge of $\overline{\text { DRDY }}$ turns off the serial data output.
Figure 8 b shows a timing diagram for a read operation where $\overline{\mathrm{RFS}}$ returns high during the transmission of the word and returns low again to access the rest of the data word. Timing parameters and functions are very similar to that outlined for

Figure 8a but Figure 8 b has a number of additional times to show timing relationships when $\overline{\mathrm{RFS}}$ returns high in the middle of transferring a word.
$\overline{\mathrm{RFS}}$ should return high during a low time of SCLK. On the rising edge of $\overline{\text { RFS }}$, the SDATA output is turned off. $\overline{\text { DRDY }}$ remains low and will remain low until all bits of the data word are read from the part, regardless of the number of times $\overline{\text { RFS }}$ changes state during the read operation. Depending on the time between the falling edge of SCLK and the rising edge of RFS, the next bit (BIT N + 1) may appear on the databus before $\overline{\text { RFS }}$ goes high. When $\overline{\text { RFS }}$ returns low again, it activates the SDATA output. When the entire word is transmitted, the DRDY line will go high, turning off the SDATA output as per Figure 8a.


Figure 8a. External Clocking Mode, Output Data Read Operation


Figure 8b. External Clocking Mode, Output Data Read Operation ( $\overline{\text { RFS }}$ Returns High During Read Operation)

## Write Operation

Data can be written to either the control register or calibration registers. In either case, the write operation is not affected by the $\overline{\mathrm{DRDY}}$ line and the write operation does not have any effect on the status of $\overline{\mathrm{DRDY}}$. A write operation to the control register or the calibration register must always write 24 bits to the respective register.
Figure 9a shows a write operation to the part with TFS remaining low for the duration of the write operation. A0 determines whether a write operation transfers data to the control register or to the calibration registers. This A0 signal must remain valid for the duration of the serial write operation. As before, the serial clock line should be low between read and write operations. The serial data to be loaded to the part must be valid on the high level of the externally applied SCLK signal. Data is clocked into the part on the high level of this SCLK signal with the MSB transferred first. On the last active high time of SCLK, the LSB is loaded to the part.

Figure 9 b shows a timing diagram for a write operation to the AD7710/AD7712 with TFS returning high during the write operation and returning low again to write the rest of the data word. Timing parameters and functions are very similar to that outlined for Figure 9a, but Figure 9b has a number of additional times to show timing relationships when TFS returns high in the middle of transferring a word.
Data to be loaded to the part must be valid for $5 / 2$ MCLK IN cycles prior to the falling edge of the SCLK signal. TFS should return high during the low time of SCLK. After TFS returns low again, the next bit of the data word to be loaded to the part is clocked in on next high level of the SCLK input. On the last active high time of the SCLK input, the LSB is loaded to the part.


Figure 9a. External Clocking Mode, Control/Calibration Register Write Operation


Figure 9b. External Clocking Mode, Control/Calibration Register Write Operation ( $\overline{\text { TFS }}$ Returns High During Write Operation)

## FEATURES

## Charge Balancing ADC <br> 24 Bits No Missing Codes $\pm 0.0015 \%$ Nonlinearity <br> Programmable Gain Front End Gains from 1 to 128 <br> Three Input Channels (AD7713) <br> Two Input Channels (AD7711) <br> Low-Pass Filter with Programmable Filter Cutoffs <br> Ability to Read/Write Calibration Coefficients <br> RTD Excitation Current Sources <br> Bidirectional Microcontroller Serial Interface Single Supply Operation <br> Low Power (AD7711: 25 mW typ; AD7713: 3.5 mW typ) <br> Power-Down Mode

## GENERAL DESCRIPTION

The AD7711/AD7713 is a complete analog front end for low frequency measurement applications. The device accepts low level signals directly from a transducer and outputs a serial digital word. It employs a sigma-delta conversion technique to realize up to 24 bits of no missing codes performance. The input signal is applied to a proprietary* programmable gain front end based around an analog modulator. The modulator output is processed by an on-chip digital filter. The first notch of this digital filter can be programmed via the on-chip control register allowing adjustment of the filter cutoff and settling time.
The AD7711 features one differential analog input and one single-ended analog input. The AD7713 features two differential inputs and one single-ended high level ( $4 \times \mathrm{V}_{\mathrm{REF}} /$ Gain ) input. Both parts feature a differential reference input and can be operated from a single +5 V supply. The AD7711 can also be operated from dual supplies to allow for negative input voltages. The parts provide two current sources which can be used to provide excitation in three-wire and four-wire RTD configurations.
The AD7711/AD7713 is ideal for use in smart, microcontrollerbased systems. Gain settings, signal polarity and RTD current control can be configured in software using the bidirectional serial port. The part contains self-calibration, system calibration and background calibration options and also allows the user to read and to write the on-chip calibration registers.
*Protected by U.S. Patent No. $\mathbf{5 , 1 3 4 , 4 0 1}$.

AD7711 FUNCTIONAL BLOCK DIAGRAM


AD7713 FUNCTIONAL BLOCK DIAGRAM


CMOS construction ensures very low power dissipation and a power-down mode reduces the stand-by power consumption to 7 mW typical (AD7711) and $300 \mu \mathrm{~W}$ typical (AD7713). The part is available in a 24 -pin, 0.3 inch wide, plastic and hermetic dual-in-line package (DIP) as well as a 24 -lead small outline (SOIC) package.


NOTES
${ }^{1}$ Temperature ranges are as follows: A Version, $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; S Version, $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. See also Note 16 .
${ }^{2}$ Applies after calibration at the temperature of interest.
${ }^{3}$ Positive full-scale error applies to both unipolar and bipolar input ranges.
${ }^{4}$ These errors will be of the order of the output noise of the part as shown in Table I.
${ }^{5}$ Recalibration at any temperature or use of the background calibration mode will remove these drift errors.
${ }^{6}$ These numbers are guaranteed by design and/or characterization.
${ }^{7}$ The AIN1 and AIN2 analog inputs present a very high impedance dynamic load which varies with clock frequency and input sample rate. The maximum recommended source resistance depends on the selected gain.
${ }^{8}$ The analog input voltage range on the AIN1 $(+)$ and AIN2(+) inputs is given here with respect to the voltage on the AIN1( - ) and AIN2( - ) inputs. The input voltage range on the AIN3 input is with respect to AGND. The absolute voltage on the AIN1 and AIN2 inputs should not go more positive than AV ${ }_{\mathrm{DD}}+$ 30 mV or more negative than AGND - 30 mV .
${ }^{9} \mathrm{~V}_{\text {REF }}=$ REF $\operatorname{IN}(+)-\operatorname{REF} \operatorname{IN}(-)$.
${ }^{10}$ This common-mode voltage range is allowed provided that the input voltage on AIN(+) and AIN( - ) does not exceed AV ${ }_{\text {DD }}+30 \mathrm{mV}$ and AGND -30 mV .
${ }^{11}$ This error can be removed using the system calibration capabilities of the AD7711/AD7713. This error is not removed by the AD7711/AD7713's selfcalibration feature. The offset drift on the AIN3 input is four times the value given in the Static Performance section.

AD7713-SPECIFICATIONS

| Parameter | A, S Versions ${ }^{1}$ | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: |
| REFERENCE INPUT <br> REF IN(+) - REF IN(-) Voltage <br> Input Sampling Rate, $\mathrm{f}_{\mathrm{S}}$ Normal-Mode 50 Hz Rejection ${ }^{6}$ Normal-Mode 60 Hz Rejection ${ }^{6}$ Common-Mode Rejection (CMR) Common-Mode 50 Hz Rejection ${ }^{6}$ Common-Mode 60 Hz Rejection ${ }^{6}$ Common-Mode Voltage Range ${ }^{10}$ DC Input Leakage Current @ $+25^{\circ} \mathrm{C}$ $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ | $\begin{aligned} & +2.5 \text { to } \mathrm{AV}_{\mathrm{DD}} / 1.8 \\ & \mathrm{f}_{\mathrm{CLK} \text { IN }} / 512 \\ & 100 \\ & 100 \\ & 100 \\ & 150 \\ & 150 \\ & \text { AGND to } \mathrm{AV}_{\mathrm{DD}} \\ & 10 \\ & 1 \end{aligned}$ | V min to V max <br> dB min <br> dB min <br> dB min <br> dB min <br> dB min <br> V min to V max <br> pA max <br> nA max | For Specified Performance. Part Is Functional with Lower $\mathrm{V}_{\text {Ref }}$ Voltages <br> For Filter Notches of $2,5,10,25,50 \mathrm{~Hz}, \pm 0.02 \times \mathrm{f}_{\mathrm{NOTCH}}$ For Filter Notches of 2, $6,10,30,60 \mathrm{~Hz}, \pm 0.02 \times \mathrm{f}_{\text {NOTCH }}$ At DC <br> For Filter Notches of 2,5, 10, 25, $50 \mathrm{~Hz}, \pm 0.02 \times \mathrm{f}_{\mathrm{NOTCH}}$ For Filter Notches of 2, 6, $10,30,60 \mathrm{~Hz}, \pm 0.02 \times \mathrm{f}_{\text {NOTCH }}$ |
| LOGIC INPUTS <br> Input Current All Inputs except MCLK IN $\mathrm{V}_{\mathrm{INL}}$, Input Low Voltage $\mathrm{V}_{\text {INH }}$, Input High Voltage MCLK IN Only $\mathrm{V}_{\text {INL }}$, Input Low Voltage $\mathrm{V}_{\mathrm{INH}}$, Input High Voltage | $\begin{aligned} & \pm 10 \\ & 0.8 \\ & 2.0 \\ & 0.8 \\ & 3.5 \end{aligned}$ | $\mu \mathrm{A}$ max <br> $V_{\text {max }}$ <br> V min <br> $V_{\text {max }}$ <br> $V$ min |  |
| LOGIC OUTPUTS <br> $\mathrm{V}_{\text {OL }}$, Output Low Voltage <br> $V_{\mathrm{OH}}$, Output High Voltage <br> Floating State Leakage Current <br> Floating State Output Capacitance ${ }^{12}$ | $\begin{array}{\|l} 0.4 \\ 4.0 \\ \pm 10 \\ 9 \end{array}$ | V max <br> V min <br> $\mu \mathrm{A}$ max <br> pF typ | $\begin{aligned} & \mathrm{I}_{\text {SINK }}=1.6 \mathrm{~mA} \\ & \mathrm{I}_{\text {SOURCE }}=100 \mu \mathrm{~A} \end{aligned}$ |
| TRANSDUCER BURN OUT <br> Current <br> Initial Tolerance <br> Drift | $\left\lvert\, \begin{aligned} & 20 \\ & \pm 10 \\ & 0.1 \end{aligned}\right.$ | $\begin{aligned} & \mathrm{nA} \text { nom } \\ & \% \text { typ } \\ & \% /{ }^{\circ} \mathrm{C} \text { typ } \end{aligned}$ |  |
| RTD EXCITATION CURRENTS <br> (RTD1, RTD2) <br> Output Current <br> Initial Tolerance <br> Drift <br> Initial Matching <br> Drift Matching <br> Line Regulation ( $\mathrm{AV}_{\mathrm{DD}}$ ) <br> Load Regulation | $\begin{array}{\|l\|} 200 \\ \pm 20 \\ 20 \\ \pm 1 \\ 3 \\ 200 \\ 200 \end{array}$ | $\mu \mathrm{A}$ nom \% max ppm $/{ }^{\circ} \mathrm{C}$ typ \% max ppm $/{ }^{\circ} \mathrm{C}$ typ nA/V max nA/V max | Matching Between RTD1 and RTD2 Currents Matching Between RTD1 and RTD2 Current Drift $A V_{D D}=+5 V$ |
| SYSTEM CALIBRATION <br> AIN1, AIN2 <br> Positive Full-Scale Calibration Limit ${ }^{13}$ <br> Negative Full-Scale Calibration Limit ${ }^{13}$ <br> Offset Calibration Limit ${ }^{14,15}$ <br> Input Span ${ }^{14}$ <br> AIN3 <br> Positive Full-Scale Calibration Limit ${ }^{13}$ Offset Calibration Limit ${ }^{15}$ Input Span | $\begin{aligned} & +\left(1.05 \times \mathrm{V}_{\mathrm{REF}}\right) / \mathrm{GAIN} \\ & -\left(1.05 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}\right. \\ & -\left(1.05 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}\right. \\ & +0.8 \times \mathrm{V}_{\mathrm{REF}} \mathrm{GAIN} \\ & +\left(2.1 \times \mathrm{V}_{\mathrm{REF}}\right) / \mathrm{GAIN} \\ & +\left(4.2 \times \mathrm{V}_{\mathrm{REF}}\right) / \mathrm{GAIN} \\ & 0 \text { to } \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN} \\ & +3.2 \times \mathrm{V}_{\mathrm{RE}} / \mathrm{GAIN} \\ & +\left(4.2 \times \mathrm{V}_{\mathrm{REF}}\right) / \mathrm{GAIN} \end{aligned}$ | $V$ max <br> $V$ max <br> $V$ max <br> $V$ min <br> V max <br> $V_{\text {max }}$ <br> $V$ max <br> $V$ min <br> V max | GAIN Is the Selected PGA Gain (Between 1 and 128) GAIN Is the Selected PGA Gain (Between 1 and 128) GAIN Is the Selected PGA Gain (Between 1 and 128) GAIN Is the Selected PGA Gain (Between 1 and 128) GAIN Is the Selected PGA Gain (Between 1 and 128) <br> GAIN Is the Selected PGA Gain (Between 1 and 128) GAIN Is the Selected PGA Gain (Between 1 and 128) GAIN Is the Selected PGA Gain (Between 1 and 128) GAIN Is the Selected PGA Gain (Between 1 and 128) |

## NOTES

${ }^{12}$ Sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance.
${ }^{13}$ After calibration, if the analog input exceeds positive full scale, the converter will output all 1 s . If the analog input is less than negative full scale, then the device will output all 0 s .
${ }^{14}$ These calibration and span limits apply provided the absolute voltage on the AIN1 and AIN2 analog inputs does not exceed AV tive than AGND - 30 mV .
${ }^{15}$ The offset calibration limit applies to both the unipolar zero point and the bipolar zero point.

| Parameter | A, S Versions ${ }^{1}$ | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: |
| POWER REQUIREMENTS |  |  |  |
| Power Supply Voltages |  |  |  |
| AV ${ }_{\text {DD }}$ Voltage ${ }^{16}$ | +5 to +10 | $V$ nom | $\pm 5 \%$ for Specified Performance |
| DV ${ }_{\text {DD }}$ Voltage ${ }^{17}$ | +5 | $V$ nom | $\pm 5 \%$ for Specified Performance |
| Power Supply Currents |  |  |  |
| AV $\mathrm{DD}^{\text {Current }}$ | 0.6 | $m A \max$ | $\mathrm{AV}_{\mathrm{DD}}=+5 \mathrm{~V}$ |
| $\mathrm{AV}_{\text {DD }}$ Current | 0.7 | mA max | $\mathrm{AV}_{\mathrm{DD}}=+10 \mathrm{~V}$ |
| DV ${ }_{\text {DD }}$ Current | 0.5 | mA max | $\mathrm{f}_{\mathrm{CLK} \text { IN }}=1 \mathrm{MHz}$. Digital Inputs 0 V or $\mathrm{DV}_{\mathrm{DD}}$ |
| DV DD $^{\text {Current }}$ | 1 | mA max | $\mathrm{f}_{\mathrm{CLK} \mathrm{IN}}=2 \mathrm{MHz}$. Digital Inputs 0 V or $\mathrm{DV}_{\text {DD }}$ |
| Power Supply Rejection ${ }^{18}$ |  |  | Rejection w.r.t. AGND |
| ( $\mathrm{AV}_{\mathrm{DD}}$ ) | See Note 19 | dB typ |  |
| Power Dissipation |  |  |  |
| Normal Mode | 5.5 | mW max | $\mathrm{AV}_{\mathrm{DD}}=\mathrm{DV} \mathrm{D}_{\mathrm{DD}}=+5 \mathrm{~V}, \mathrm{f}_{\mathrm{CLK} \mathrm{IN}}=1 \mathrm{MHz}$ <br> Typically 3.5 mW |
| Standby (Power-Down) Mode | 500 | $\mu \mathrm{W}$ max | $\mathrm{AV}_{\mathrm{DD}}=\mathrm{DV}_{\mathrm{DD}}=+5 \mathrm{~V}$; Typically $300 \mu \mathrm{~W}$ |

## NOTES

${ }^{16}$ Operation with $\mathrm{AV}_{\mathrm{DD}}$ voltages in the range 5.25 V to 10.5 V is only guaranteed over the $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ temperature range.
${ }^{17}$ The $\pm 5 \%$ tolerance on the $D V_{D D}$ input is allowed provided that $D V_{D D}$ does not exceed $A V_{D D}$ by more than 0.3 V .
${ }^{18}$ Measured at dc and applies in the selected passband. PSRR at 50 Hz will exceed 120 dB with filter notches of $2,5,10,25$ or 50 Hz . PSRR at 60 Hz will exceed 120 dB with filter notches of $2,6,10,30$ or 60 Hz .
${ }^{19}$ PSRR depends on gain: Gain of $1=70 \mathrm{~dB}$ typ; Gain of $2=75 \mathrm{~dB}$ typ; Gain of $4=80 \mathrm{~dB}$ typ; Gains of 8 to $128=85 \mathrm{~dB}$ typ.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS*

( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)
$A V_{D D}$ to AGND . . . . . . . . . . . . . . . . . . . -0.3 V to +12 V
$A V_{D D}$ to DGND . . . . . . . . . . . . . . . . -0.3 V to +12 V
$\mathrm{DV}_{\mathrm{DD}}$ to AGND . . . . . . . . . . . . . . . . . . -0.3 V to +6 V
$\mathrm{DV}_{\mathrm{DD}}$ to DGND . . . . . . . . . . . . . . . . . . . -0.3 V to +6 V
AGND to DGND . . . . . . . . . . . . . . . . . . . -0.3 V to +6 V
AIN1, AIN2 Input Voltage
to AGND . . . . . . . . . . . . . . -0.3 V to $\mathrm{AV}_{\mathrm{DD}}+0.3 \mathrm{~V}$
AIN3 Input Voltage to AGND . . . . . . . . . -0.3 V to +22 V
Reference Input Voltage to AGND . . -0.3 V to $\mathrm{AV}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Digital Input Voltage to DGND . . -0.3 V to $\mathrm{AV}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Digital Output Voltage to DGND . . -0.3 V to $\mathrm{DV}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Operating Temperature Range
Commercial (A Version) . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Extended (S Version) . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

Junction Temperature . . . . . . . . . . . . . . . . . . . . . . $+150^{\circ} \mathrm{C}$
Plastic DIP Package, Power Dissipation . . . . . . . . . . 450 mW
$\theta_{\mathrm{JA}}$ Thermal Impedance . . . . . . . . . . . . . . . . . . $105^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature, Soldering ( 10 sec ) . . . . . . . . . . $+260^{\circ} \mathrm{C}$
Cerdip Package, Power Dissipation . . . . . . . . . . . . . 450 mW
$\theta_{\mathrm{JA}}$ Thermal Impedance . . . . . . . . . . . . . . . . . . . $70^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature, Soldering . . . . . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
SOIC Package, Power Dissipation . . . . . . . . . . . . . . 450 mW
$\theta_{\mathrm{JA}}$ Thermal Impedance . . . . . . . . . . . . . . . . . . . $75^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature, Soldering
Vapor Phase ( 60 sec ) . . . . . . . . . . . . . . . . . . . . $+215^{\circ} \mathrm{C}$
Infrared ( 15 sec ) . . . . . . . . . . . . . . . . . . . . . . $+220^{\circ} \mathrm{C}$
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V , which readily accumulate on the human body and on test equipment, can discharge without detection. Although devices feature proprietary ESD protection circuitry, permanent damage may still occur on these devices if they are subjected to high energy electrostatic discharges. Therefore, proper precautions are recommended to avoid any performance degradation or loss of functionality.


AD7713 ORDERING GUIDE

| Model $^{\mathbf{1}}$ | Temperature Range | Package Option |
| :--- | :--- | :--- |
| AD7713AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-24$ |
| AD7713AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-24$ |
| AD7713AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-24$ |
| AD7713SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-24$ |

## NOTES

${ }^{1}$ To order MIL-STD-883B, Class B processed parts, add /883B to part number. Contact your local sales office for military data sheet and availability. ${ }^{2} \mathrm{~N}=$ Plastic DIP; $\mathrm{Q}=$ Cerdip; $\mathrm{R}=$ SOIC. For outline information see Package Information section.

$$
\left(A V_{D D}=+5 V \pm 5 \% ; D V_{D D}=+5 V \pm 5 \% ; V_{S S}=0 V \text { or }-5 V \pm 5 \% ;\right.
$$

AD7711-SPECIFICATIONS REF IN $(+)=+2.5 \mathrm{~V}$; REF IN( - ) = AGND; MCLK IN $=10 \mathrm{MHz}$ unless otherwise stated. All specifications $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {max }}$, unless otherwise noted.)

| Parameter | A, S Versions ${ }^{1}$ | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: |
| STATIC PERFORMANCE <br> No Missing Codes <br> Output Noise <br> Integral Nonlinearity <br> @ $25^{\circ} \mathrm{C}$ <br> $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ <br> Positive Full-Scale Error ${ }^{2,3}$ <br> Full-Scale Drift ${ }^{5}$ <br> Unipolar Offset Error ${ }^{2}$ <br> Unipolar Offset Drift ${ }^{5}$ <br> Bipolar Zero Error ${ }^{2}$ <br> Bipolar Zero Drift ${ }^{5}$ <br> Bipolar Negative Full-Scale Error ${ }^{2}$ <br> Bipolar Negative Full-Scale Drift ${ }^{5}$ | $\begin{aligned} & 24 \\ & 22 \\ & 18 \\ & 15 \\ & 12 \\ & \text { See Tables I \& II } \\ & \\ & \pm 0.0045 \\ & \pm 0.0075 \\ & \text { See Note } 4 \\ & \text { 3/GAIN } \\ & 0.35 \\ & \text { See Note 4 } \\ & 2.5 / \text { GAIN } \\ & 0.3 \\ & \text { See Note } 4 \\ & 2.5 / \text { GAIN } \\ & 0.3 \\ & \pm 0.006 \\ & 4 / \text { GAIN } \\ & 0.5 \end{aligned}$ | Bits min <br> Bits min <br> Bits min <br> Bits min <br> Bits min <br> \% of FSR max <br> $\%$ of FSR max <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ <br> $\%$ of FSR max <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ | Guaranteed by Design. For Filter Notches $\leq 60 \mathrm{~Hz}$ <br> For Filter Notch $=100 \mathrm{~Hz}$ <br> For Filter Notch $=250 \mathrm{~Hz}$ <br> For Filter Notch $=500 \mathrm{~Hz}$ <br> For Filter Notch $=1 \mathrm{kHz}$ <br> Depends on Filter Cutoffs and Selected Gain <br> Filter Notches $\leq 60 \mathrm{~Hz}$. Typically $\pm 0.0015 \%$ <br> Filter Notches $\leq 60 \mathrm{~Hz}$ <br> Excluding Reference <br> Excluding Reference. For Gains of 1, 2, 4, 8 <br> Excluding Reference. For Gains of 16, 32, 64, 128 <br> For Gains of $1,2,4,8$ <br> For Gains of 16, 32, 64, 128 <br> For Gains of $1,2,4,8$ <br> For Gains of 16, 32, 64, 128 <br> Excluding Reference. Typically $\pm 0.0015 \%$ <br> Excluding Reference. For Gains of 1, 2, 4, 8 <br> Excluding Reference. For Gains of 16, 32, 64, 128 |
| ANALOG INPUTS/REFERENCE INPUTS <br> Normal Mode 50 Hz Rejection ${ }^{6}$ <br> Normal Mode 60 Hz Rejection ${ }^{6}$ <br> DC Input Leakage Current ${ }^{6} @+25^{\circ} \mathrm{C}$ <br> $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ <br> Sampling Capacitance ${ }^{6}$ <br> AIN1/REF IN <br> Common-Mode Rejection (CMR) <br> Common-Mode 50 Hz Rejection ${ }^{6}$ <br> Common-Mode 60 Hz Rejection ${ }^{6}$ <br> Common-Mode Voltage Range ${ }^{7}$ <br> Analog Inputs ${ }^{8}$ <br> Input Voltage Range ${ }^{9}$ <br> Input Sampling Rate, $\mathrm{f}_{\mathrm{S}}$ <br> AIN2 Offset Error <br> AIN2 Offset Drift <br> Reference Inputs REF IN(+) - REF IN(-) Voltage ${ }^{11}$ <br> Input Sampling Rate, $\mathrm{f}_{\mathrm{S}}$ | $\begin{aligned} & 100 \\ & 100 \\ & 10 \\ & 1 \\ & 20 \\ & 92 \\ & 150 \\ & 150 \\ & \mathrm{~V}_{\mathrm{SS}} \text { to AV } \mathrm{DD} \\ & \\ & 0 \text { to }+\mathrm{V}_{\mathrm{REF}}{ }^{10} \\ & \pm \mathrm{V}_{\mathrm{REF}} \\ & \text { See Table III } \\ & 4 \\ & 2 \\ & \\ & +2.5 \text { to }+5 \\ & \\ & \mathrm{f}_{\mathrm{CLK} \text { IN }} / 512 \end{aligned}$ | dB min <br> dB min <br> pA max <br> nA max <br> pF max <br> dB min <br> dB min <br> dB min <br> V min to V max <br> $\max$ <br> $\max$ <br> $m V \max$ <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ <br> $\mathrm{V} \min$ to V max | For Filter Notches of $10,25,50 \mathrm{~Hz}, \pm 0.02 \times \mathrm{f}_{\mathrm{NOTCH}}$ For Filter Notches of $10,30,60 \mathrm{~Hz}, \pm 0.02 \times \mathrm{f}_{\text {NOTCH }}$ <br> At DC <br> For Filter Notches of $10,25,50 \mathrm{~Hz}, \pm 0.02 \times \mathrm{f}_{\text {NOTCH }}$ <br> For Filter Notches of $10,30,60 \mathrm{~Hz}, \pm 0.02 \times \mathrm{f}_{\text {NOTCH }}$ <br> For Normal Operation. Depends on Gain Selected. <br> Unipolar Input Range (B/U Bit of Control Register = 1) <br> Bipolar Input Range ( $\mathrm{B} / \mathrm{U}$ Bit of Control Register $=0$ ) <br> Removed by System Calibrations but not by Self-Calibration Removed by System Calibration but not by Self-Calibration <br> For Specified Performance; Part Is Functional with Lower $\mathrm{V}_{\text {REF }}$ Voltages |
| REFERENCE OUTPUT <br> Output Voltage <br> Initial Tolerance <br> Drift <br> Output Noise <br> Line Regulation ( $\mathrm{AV} \mathrm{DD}_{\mathrm{DD}}$ ) <br> Load Regulation <br> External Current | $\begin{aligned} & 2.5 \\ & \pm 4 \\ & 25 \\ & 50 \\ & 1 \\ & 1.5 \\ & 1 \end{aligned}$ | V nom \% max $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ typ $\mu \mathrm{V}$ typ $\mathrm{mV} / \mathrm{V}$ max $\mathrm{mV} / \mathrm{mA}$ max $m A$ max | pk-pk Noise. 0.1 Hz to 10 Hz Bandwidth <br> Maximum Load Current 1 mA |

NOTES
${ }^{1}$ Temperature ranges are as follows: A Version, $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; S Version, $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. See also Note 16 .
${ }^{2}$ Applies after calibration at the temperature of interest.
${ }^{3}$ Positive full-scale error applies to both unipolar and bipolar input ranges.
${ }^{4}$ These errors will be of the order of the output noise of the part as shown in Table I.
${ }^{5}$ Recalibration at any temperature or use of the background calibration mode will remove these drift errors.
${ }^{6}$ These numbers are guaranteed by design and/or characterization.
${ }^{7}$ This common-mode voltage range is allowed, provided that the input voltage on $\operatorname{AIN}(+)$ or $\operatorname{AIN}(-)$ does not exceed $\mathrm{AV}_{\mathrm{DD}}+30 \mathrm{mV}$ and $\mathrm{V}_{\mathrm{Ss}}-30 \mathrm{mV}$.
${ }^{8}$ The analog inputs present a very high impedance dynamic load which varies with clock frequency and input sample rate. The maximum recommended source resistance depends on the selected gain (see Tables IV and V).
${ }^{9}$ The analog input voltage range on the $\operatorname{AIN1}(+)$ input is given here with respect to the voltage on the AIN1(-) input. The input voltage range on the AIN2 input is with respect to AGND. The absolute voltage on the analog inputs should not go more positive than $\mathrm{AV}_{\mathrm{DD}}+30 \mathrm{mV}$ or go more negative than $\mathrm{V}_{\mathrm{SS}}-30 \mathrm{mV}$.
${ }^{10} \mathrm{~V}_{\text {REF }}=\operatorname{REF} \operatorname{IN}(+)-\operatorname{REF} \operatorname{IN}(-)$.
${ }^{11}$ The reference voltage range may be restricted by the input voltage range requirement on the $V_{\text {BIAS }}$ input.

| Parameter | A, S Versions ${ }^{1}$ | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {BIAS }}$ INPUT $^{12}$ Input Voltage Range <br> $\mathrm{V}_{\text {BIAS }}$ Rejection | $\begin{aligned} & \mathrm{AV}_{\mathrm{DD}}-0.85 \times \mathrm{V}_{\mathrm{REF}} \\ & \text { or } \mathrm{AV}_{\mathrm{DD}}-3 \\ & \\ & \text { or } \mathrm{AV}_{\mathrm{DD}}-2.1 \\ & \mathrm{~V}_{\mathrm{SS}}+0.85 \times \mathrm{V}_{\mathrm{REF}} \\ & \text { or } \mathrm{V}_{\mathrm{SS}}+3 \\ & \text { or } \mathrm{V}_{\mathrm{SS}}+2.1 \\ & 65 \text { to } 85 \end{aligned}$ | V max <br> V max <br> $V_{\text {min }}$ <br> $V$ min <br> dB typ | See $\mathrm{V}_{\text {bias }}$ Input Section <br> Whichever Is Smaller; $+5 \mathrm{~V} /-5 \mathrm{~V}$ or $+10 \mathrm{~V} / 0 \mathrm{~V}$ <br> Nominal $\mathrm{AV}_{\mathrm{DD}} / \mathrm{V}_{\mathrm{ss}}$ <br> Whichever Is Smaller; $+5 \mathrm{~V} / 0 \mathrm{~V}$ Nominal $\mathrm{AV}_{\mathrm{DD}} / \mathrm{V}_{\mathrm{Ss}}$ <br> See $\mathrm{V}_{\text {bias }}$ Input Section <br> Whichever Is Greater; $+5 \mathrm{~V} /-5 \mathrm{~V}$ or $+10 \mathrm{~V} / 0 \mathrm{~V}$ <br> Nominal $\mathrm{AV}_{\mathrm{DD}} / \mathrm{V}_{\mathrm{ss}}$ <br> Whichever Is Greater; $+5 \mathrm{~V} / 0 \mathrm{~V}$ Nominal $\mathrm{AV}_{\mathrm{DD}} / \mathrm{V}_{\mathrm{ss}}$ <br> Increasing with Gain |
| LOGIC INPUTS <br> Input Current All Inputs except MCLK IN <br> $\mathrm{V}_{\text {INL }}$, Input Low Voltage <br> $\mathrm{V}_{\text {INH }}$, Input High Voltage MCLK IN Only <br> $\mathrm{V}_{\text {INL }}$, Input Low Voltage <br> $\mathrm{V}_{\text {INH }}$, Input High Voltage | $\begin{aligned} & \pm 10 \\ & 0.8 \\ & 2.0 \\ & 0.8 \\ & 3.5 \end{aligned}$ | $\mu \mathrm{A}$ max <br> V max <br> V min <br> V max <br> V min |  |
| LOGIC OUTPUTS <br> $\mathrm{V}_{\text {OL }}$, Output Low Voltage <br> $\mathrm{V}_{\mathrm{OH}}$, Output High Voltage <br> Floating State Leakage Current Floating State Output Capacitance ${ }^{13}$ | $\begin{array}{\|l} 0.4 \\ 4.0 \\ \pm 10 \\ 9 \end{array}$ | $V_{\text {max }}$ <br> V min <br> $\mu \mathrm{A}$ max <br> pF typ | $\begin{aligned} & \mathrm{I}_{\text {SINK }}=1.6 \mathrm{~mA} \\ & \mathrm{I}_{\text {SOURCE }}=100 \mu \mathrm{~A} \end{aligned}$ |
| TRANSDUCER BURN-OUT Current Initial Tolerance Drift | $\left\lvert\, \begin{aligned} & 100 \\ & \pm 10 \\ & 0.1 \end{aligned}\right.$ | nA nom <br> \% typ <br> $\% /{ }^{\circ} \mathrm{C}$ typ |  |
| RTD EXCITATION CURRENTS (RTD <br> Output Current <br> Initial Tolerance <br> Drift <br> Initial Matching <br> Drift Matching <br> Line Regulation ( $\mathrm{AV}_{\mathrm{DD}}$ ) <br> Load Regulation <br> Output Compliance | $\begin{aligned} & \hline 2) \\ & 200 \\ & \pm 20 \\ & 20 \\ & \pm 1 \\ & 3 \\ & 200 \\ & 200 \\ & \mathrm{AV}_{\mathrm{DD}}-2 \end{aligned}$ | $\mu \mathrm{A}$ nom \% max ppm $/{ }^{\circ} \mathrm{C}$ typ \% max ppm $/{ }^{\circ} \mathrm{C}$ typ $n A / V \max$ $n A / V \max$ V max | Matching Between RTD1 and RTD2 Currents Matching Between RTD1 and RTD2 Current Drift $A V_{D D}=+5 V$ |
| SYSTEM CALIBRATION <br> Positive Full-Scale Calibration Limit ${ }^{14}$ Negative Full-Scale Calibration Limit ${ }^{14}$ Offset Calibration Limit ${ }^{15}$ Input Span ${ }^{15}$ | $\begin{aligned} & \left(1.05 \times \mathrm{V}_{\text {REF }}\right) / \text { GAIN } \\ & -\left(1.05 \times \mathrm{V}_{\text {REF }} /\right. \text { GAIN } \\ & -\left(1.05 \times \mathrm{V}_{\text {REF }} /\right. \text { GAIN } \\ & 0.8 \times \mathrm{V}_{\text {REF }} / \text { GAIN } \\ & \left(2.1 \times \mathrm{V}_{\text {REF }} /\right. \text { GAIN } \\ & \hline \end{aligned}$ | $V$ max <br> V max <br> $V_{\text {max }}$ <br> V min <br> V max | GAIN Is the Selected PGA Gain (Between 1 and 128) GAIN Is the Selected PGA Gain (Between 1 and 128) GAIN Is the Selected PGA Gain (Between 1 and 128) GAIN Is the Selected PGA Gain (Between 1 and 128) GAIN Is the Selected PGA Gain (Between 1 and 128) |

## NOTES

${ }^{12}$ The AD7711 is tested with the following $\mathrm{V}_{\text {BIAs }}$ voltages. With $A \mathrm{~V}_{\mathrm{DD}}=+5 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{~V}_{\text {BIAS }}=+2.5 \mathrm{~V}$; with AV DD $=+10 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{BIAS}}$ $=+5 \mathrm{~V}$ and with $\mathrm{AV}_{\mathrm{DD}}=+5 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{SS}}=-5 \mathrm{~V}, \mathrm{~V}_{\mathrm{BIAS}}=0 \mathrm{~V}$.
${ }^{13}$ Sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance.
${ }^{14}$ After calibration, if the analog input exceeds positive full scale, then the converter will output all 1s. If the analog input is less than negative full scale, then the device will output all 0s.
${ }^{15}$ These calibration and span limits apply provided that the absolute voltage on the analog inputs does not exceed $\mathrm{AV}_{\mathrm{DD}}+30 \mathrm{mV}$ or does not go more negative than $\mathrm{V}_{\mathrm{ss}}-30 \mathrm{mV}$. The offset calibration limit applies to both the unipolar zero point and the bipolar zero point.

| Parameter | A, S Versions ${ }^{1}$ | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: |
| POWER REQUIREMENTS |  |  |  |
| Power Supply Voltages |  |  |  |
| $\mathrm{AV}_{\text {DD }}$ Voltage $^{16}$ | +5 to +10 | V nom | $\pm 5 \%$ for Specified Performance |
| DV ${ }_{\text {DD }}$ Voltage $^{17}$ | +5. | $V$ nom | $\pm 5 \%$ for Specified Performance |
| AV $\mathrm{DD}^{-} \mathrm{V}_{\text {SS }}$ Voltage | $+10.5$ | $V$ max | For Specified Performance |
| Power Supply Currents |  |  |  |
| $\mathrm{AV}_{\text {DD }}$ Current | 4 | mA max |  |
| DV ${ }_{\text {DD }}$ Current | 4.5 | mA max |  |
| $V_{\text {SS }}$ Current | 1.5 | mA max | $\mathrm{V}_{\text {Ss }}=-5 \mathrm{~V}$ |
| Power Supply Rejection ${ }^{18}$ |  |  | Rejection w.r.t. AGND; Assumes V $\mathrm{VIIAS}^{\text {Is }}$ Isixed |
| Positive Supply ( $\mathrm{AV}_{\mathrm{DD}}$ ) | See Note 19 | dB typ |  |
| Negative Supply ( $\mathrm{V}_{\text {SS }}$ ) | 90 | dB typ |  |
| Power Dissipation |  |  |  |
| Normal Mode | 45 |  | $\mathrm{AV}_{\mathrm{DD}}=\mathrm{DV}_{\mathrm{DD}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{Ss}}=0 \mathrm{~V}$; Typically 25 mW |
| Normal Mode | 52.5 | mW max | $A \mathrm{~V}_{\mathrm{DD}}=\mathrm{DV}_{\mathrm{DD}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{Ss}}=-5 \mathrm{~V}$; Typically 30 mW |
| Standby (Power-Down) Mode | 15 | mW max | $\mathrm{AV}_{\mathrm{DD}}=\mathrm{DV}_{\mathrm{DD}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{ss}}=0 \mathrm{~V} \text { or }-5 \mathrm{~V}$ <br> Typically 7 mW |

${ }^{16}$ The AD7711 is specified with a 10 MHz clock for $\mathrm{AV}_{\mathrm{DD}}$ voltages of $+5 \mathrm{~V} \pm 5 \%$. It is specified with an 8 MHz clock for $\mathrm{AV}_{\mathrm{DD}}$ voltages greater than 5.25 V and less than 10.5 V . Operating with $\mathrm{AV}_{\mathrm{DD}}$ voltages in the range 5.25 V to 10.5 V is only guaranteed over the $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ temperature range.
${ }^{17}$ The $\pm 5 \%$ tolerance on the $D V_{D D}$ input is allowed provided that $D V_{D D}$ does not exceed $A V_{D D}$ by more than 0.3 V .
${ }^{18}$ Measured at dc and applies in the selected passband. PSRR at 50 Hz will exceed 120 dB with filter notches of $10 \mathrm{~Hz}, 25 \mathrm{~Hz}$ or 50 Hz . PSRR at 60 Hz will exceed 120 dB with filter notches of $10 \mathrm{~Hz}, 30 \mathrm{~Hz}$ or 60 Hz .
${ }^{19}$ PSRR depends on gain: Gain of $1=70 \mathrm{~dB}$ typ; Gain of $2=75 \mathrm{~dB}$ typ; Gain of $4=80 \mathrm{~dB}$ typ; Gains of 8 to $128=85 \mathrm{~dB}$ typ. These numbers can be improved (to 95 dB typ) by deriving the $\mathrm{V}_{\text {BIAS }}$ voltage (via Zener diode or reference) from the $A V_{D D}$ supply.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS*

( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)


$A V_{D D}$ to AGND . . . . . . . . . . . . . . . . . . . -0.3 V to +12 V

$\mathrm{DV}_{\mathrm{DD}}$ to AGND . . . . . . . . . . . . . . . . . . . -0.3 V to +6 V
$\mathrm{DV}_{\mathrm{DD}}$ to $\mathrm{DGND} . . . . . . . . . . . . . . . . . .-0.3 \mathrm{~V}$ to +6 V
$\mathrm{V}_{\text {Ss }}$ to AGND . . . . . . . . . . . . . . . . . . . . . +0.3 V to -6 V
$\mathrm{V}_{\mathrm{ss}}$ to DGND . . . . . . . . . . . . . . . . . . . . . +0.3 V to -6 V
Analog Input Voltage to AGND
$\mathrm{V}_{\mathrm{Ss}}-0.3 \mathrm{~V}$ to $\mathrm{AV}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Reference Input Voltage to AGND
$\ldots . .$.
REF OUT to AGND . . . . . . . . . . . . . . . . -0.3 V to $\mathrm{AV}_{\mathrm{DD}}$
Digital Input Voltage to DGND . . . -0.3 V to $\mathrm{AV}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Digital Output Voltage to DGND . . -0.3 V to $\mathrm{DV}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Operating Temperature Range
Commercial (A Version) . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Extended (S Version) . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range ..... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Junction Temperature ..... $+150^{\circ} \mathrm{C}$
Plastic DIP Package, Power Dissipation ..... 450 mW
$\theta_{\mathrm{JA}}$ Thermal Impedance ..... $105^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature, Soldering ( 10 sec ) ..... $+260^{\circ} \mathrm{C}$
Cerdip Package, Power Dissipation ..... 450 mW
$\theta_{\mathrm{JA}}$ Thermal Impedance ..... $70^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature, Soldering ..... $+300^{\circ} \mathrm{C}$
SOIC Package, Power Dissipation ..... 450 mW
$\theta_{\mathrm{JA}}$ Thermal Impedance ..... $75^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature, Soldering
Vapor Phase ( 60 sec ) ..... $+215^{\circ} \mathrm{C}$
Infrared ( 15 sec ) ..... $+220^{\circ} \mathrm{C}$
*Stresses above those listed under "Absolute Maximum Ratings" may causepermanent damage to the device. This is a stress rating only and functionaloperation of the device at these or any other conditions above those listed in theoperational sections of this specification is not implied. Exposure to absolutemaximum rating conditions for extended periods may affect device reliability.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD7711 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


AD7711 ORDERING GUIDE

| Model | Temperature Range | Package Option ${ }^{\star}$ |
| :--- | :--- | :--- |
| AD7711AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-24$ |
| AD7711AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-24$ |
| AD7711AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-24$ |
| AD7711SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-24$ |

${ }^{\star} \mathrm{N}=$ Plastic DIP; Q = Cerdip; R = SOIC. For outline information see Package Information section.

TIMING CHARACTERISTICS ${ }^{1,2}$
$\left(D V_{D D}=+5 V \pm 5 \% ; A V_{D D}=+5 V\right.$ or $+10 V^{3} \pm 5 \% ; A G N D=D G N D=0 V ; f_{C L K}=$ 10 MHz (AD7711) or 2 MHz (AD7713); Input Logic $0=0 \mathrm{~V}$, Logic $1=\mathrm{DV}_{\mathrm{DD}}$ unless otherwise stated.)

| Parameter | Limit at $\mathbf{T}_{\text {MIN }}, \mathbf{T}_{\text {MAX }}$ (A, S Versions) | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: |
| $\mathrm{f}_{\text {CLK IN }}{ }^{4,5}$ | 400 | kHz min | Master Clock Frequency |
|  | 2 | MHz max | AD7713 |
|  | 10 | MHz max | AD7711 |
| $\mathrm{t}_{\text {CLK IN }}$ LO | $0.4 \times \mathrm{t}_{\text {CLK }}{ }_{\text {IN }}$ | ns min | Master Clock Input Low Time; $\mathrm{t}_{\text {CLK IN }}=1 / \mathrm{f}_{\text {CLK IN }}$ |
| $\mathrm{t}_{\text {CLK IN HI }}$ | $0.4 \times \mathrm{t}_{\text {CLK }} \mathrm{IN}$ | ns min | Master Clock Input High Time |
| $\mathrm{t}_{\mathrm{r}}{ }^{6}$ | 50 | ns max | Digital Output Rise Time; Typically 20 ns |
| $\mathrm{t}_{\mathrm{f}}{ }^{6}$ | 50 | ns max | Digital Output Fall Time; Typically 20 ns |
| $\mathrm{t}_{1}$ | 1000 | ns min | $\overline{\text { SYNC Pulse Width }}$ |
| Self-Clocking Mode |  |  |  |
| $\mathrm{t}_{2}$ | 0 | ns min | $\overline{\text { DRDY }}$ to $\overline{\text { RFS }}$ Setup Time |
| $\mathrm{t}_{3}$ | 0 | ns min | $\overline{\text { DRDY }}$ to $\overline{\text { RFS }}$ Hold Time |
| $\mathrm{t}_{4}$ | $2 \times \mathrm{t}_{\text {CLK IN }}$ | ns min | A0 to $\overline{\mathrm{RFS}}$ Setup Time |
| $\mathrm{t}_{5}$ | 50 | ns min | A0 to $\overline{\mathrm{RFS}}$ Hold Time |
| $\mathrm{t}_{6}$ | $4 \times \mathrm{t}_{\text {CLK }} \mathrm{IN}$ | ns max | $\overline{\mathrm{RFS}}$ Low to SCLK Falling Edge |
| $\mathrm{t}_{7}{ }_{7}$ | $4 \times \mathrm{t}_{\text {CLK }} \mathrm{IN}$ | ns max | Data Access Time ( $\overline{\mathrm{RFS}}$ Low to Data Valid) |
| $\mathrm{t}_{8}{ }^{7}$ | $\begin{aligned} & \mathrm{t}_{\mathrm{CLK} \mathrm{IN}} / 2 \\ & \mathrm{t}_{\mathrm{CLK} \mathrm{IN}} / 2+30 \end{aligned}$ | ns min ns max | SCLK Falling Edge to Data Valid Delay |
| $\mathrm{t}_{9}$ | $\mathrm{t}_{\text {CLK IN }} / 2$ | ns nom | SCLK High Pulse Width |
| $\mathrm{t}_{10}$ | $3 \times \mathrm{t}_{\text {CLK IN }} / 2$ | ns nom | SCLK Low Pulse Width |
| $\mathrm{t}_{11}$ | $10$ | ns min <br> ns max | $\overline{\mathrm{RFS}} / \overline{\mathrm{TFS}}$ to SCLK Falling Edge Hold Time |
|  |  | ns max | $\overline{\mathrm{RFS}} / \overline{\mathrm{TFS}}$ to SCLK Delay |
| $\mathrm{t}_{13}{ }^{8}$ | $3 \times \mathrm{t}_{\text {CLK }}^{\text {IN }}$ / $2+20$ | ns max | $\overline{\mathrm{RFS}}$ to Data Valid Hold Time |
| $\mathrm{t}_{14}$ | 0 | ns min | A0 to TFS Setup Time |
| $\mathrm{t}_{15}$ | 0 | $n \mathrm{n}$ min | A0 to TFS Hold Time |
| $\mathrm{t}_{16}$ | $4 \times \mathrm{t}_{\text {CLK IN }}$ | ns max | $\overline{\mathrm{TFS}}$ to SCLK Falling Edge Delay Time |
| $\mathrm{t}_{17}$ | $4 \times \mathrm{t}_{\text {CLK }} \mathrm{IN}$ | ns min | $\overline{T F S}$ to SCLK Falling Edge Hold Time |
| $\mathrm{t}_{18}$ | 0 | ns min | Data Valid to SCLK Setup Time |
| $\mathrm{t}_{19}$ | 10 | ns min | Data Valid to SCLK Hold Time |



Figure 1. Load Circuit for Access Time and Bus Relinquish Time

| Parameter | Limit at $\mathbf{T}_{\text {MIN }}, \mathbf{T}_{\text {MAX }}$ (A, S Versions) | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: |
| External-Clocking Mode |  |  |  |
| $\mathrm{f}_{\text {SCLK }}$ | $\mathrm{f}_{\text {CLK IN }} / 5$ | MHz max | Serial Clock Input Frequency |
| $\mathrm{t}_{20}$ | 0 | ns min | $\overline{\text { DRDY }}$ to RFS Setup Time |
| $\mathrm{t}_{21}$ | 0 | ns min | $\overline{\text { DRDY }}$ to $\overline{\text { RFS }}$ Hold Time |
| $\mathrm{t}_{22}$ | $2 \times \mathrm{t}_{\text {CLK }} \mathrm{IN}$ | ns min | A0 to $\overline{\mathrm{RFS}}$ Setup Time |
| $\mathrm{t}_{23}$ | 50 | ns min | A0 to $\overline{\mathrm{RFS}}$ Hold Time |
| $\mathrm{t}_{24}{ }_{7}$ | $4 \times \mathrm{t}_{\text {CLK }} \mathrm{IN}$ | ns max | Data Access Time ( $\overline{\mathrm{RFS}}$ Low to Data Valid) |
| $\mathrm{t}_{25}{ }^{7}$ | $\begin{aligned} & \mathrm{t}_{\mathrm{CLK} \text { IN }} / 2 \\ & 2 \times \mathrm{t}_{\mathrm{CLK} \text { IN }}+20 \end{aligned}$ | ns min ns max | SCLK Falling Edge to Data Valid Delay |
| $\mathrm{t}_{26}$ | $2 \times \mathrm{t}_{\text {CLK }} \mathrm{IN}$ | ns min | SCLK High Pulse Width |
| $\mathrm{t}_{27}$ | $2 \times \mathrm{t}_{\text {CLK }} \mathrm{IN}$ | ns min | SCLK Low Pulse Width |
| $\mathrm{t}_{28}$ | $\mathrm{t}_{\text {CLK IN }}+10$ | ns max | SCLK Falling Edge to DRDY High |
| $\mathrm{t}_{29}{ }^{8}$ |  | ns min | $\overline{\text { DRDY }}$ to Data Valid Hold Time |
|  | 20 | ns max |  |
| $\mathrm{t}_{30}{ }_{8}$ | ${ }_{5}^{10} \times 2$ | ns min | $\overline{\mathrm{RFS}} / \overline{\mathrm{TFS}}$ to SCLK Falling Edge Hold Time |
| $\mathrm{t}_{31}{ }^{8}$ | $5 \times \mathrm{t}_{\text {CLK IN }} / 2+20$ | ns max | $\overline{\text { RFS }}$ to Data Valid Hold Time |
| $\mathrm{t}_{32}$ | 0 | ns min | A0 to TFS Setup Time |
| $\mathrm{t}_{3}$ | 0 | ns min | A0 to TFS Hold Time |
| $\mathrm{t}_{34}$ | $4 \times \mathrm{t}_{\text {CLK IN }}$ | ns min | SCLK Falling Edge to TFS Hold Time |
| $\mathrm{t}_{35}$ | $5 \times \mathrm{t}_{\text {cLK }} / 2-$ SCLK High | ns min | Data Valid to SCLK Setup Time |
| $\mathrm{t}_{36}$ | 30 | ns min | Data Valid to SCLK Hold Time |

NOTES
${ }^{1}$ Sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance. All input signals are specified with $\mathrm{t}_{\mathrm{R}}=\mathrm{t}_{\mathrm{F}}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of 5 V$)$ and timed from a voltage level of 1.6 V .
${ }^{2}$ See Figures 6 to 9 of AD7710/AD7712 data sheet.
${ }^{3}$ Operation with $\mathrm{AV}_{\mathrm{DD}}$ voltages in the range 5.25 V to 10.5 V is only guaranteed over the $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ temperature range.
${ }^{4}$ CLK IN duty cycle range is $45 \%$ to $55 \%$. CLK IN must be supplied whenever the AD7711/AD7713 is not in STANDBY mode. If no clock is present in this case, the device can draw higher current than specified and possibly become uncalibrated.
${ }^{5}$ The AD7711 is production tested at 10 MHz . The AD7713 is production tested with $\mathrm{f}_{\text {CLK IN }}$ at 2 MHz . Both are guaranteed by characterization to operate at 400 kHz .
${ }^{6}$ Specified using $10 \%$ and $90 \%$ points on waveform of interest.
${ }^{7}$ These numbers are measured with the load circuit of Figure 1 and defined as the time required for the output to cross 0.8 V or 2.4 V .
${ }^{8}$ These numbers are derived from the measured time taken by the data output to change 0.5 V when loaded with the circuit of Figure 1 . The measured number is then extrapolated back to remove effects of charging or discharging the 100 pF capacitor. This means that the times quoted in the timing characteristics are the true bus relinquish times of the part and as such are independent of external bus loading capacitances.

## AD7711 PIN CONFIGURATION

## DIP and SOIC



## AD7713 PIN CONFIGURATION

## DIP and SOIC



PIN FUNCTION DESCRIPTION

| Mnemonic | Function |
| :---: | :---: |
| SCLK | Serial Clock. Logic input/output depending on the status of the MODE pin. When MODE is high, the device is in its self-clocking mode and the SCLK pin provides a serial clock output. This SCLK becomes active when $\overline{\mathrm{RFS}}$ or $\overline{\mathrm{TFS}}$ goes low and it goes high impedance when either $\overline{\mathrm{RFS}}$ or $\overline{\mathrm{TFS}}$ returns high or when the device has completed transmission of an output word. When MODE is low, the device is in its external clocking mode and the SCLK pin acts as an input. This input serial clock can be a continuous clock with all data transmitted in a continuous train of pulses. Alternatively, it can be a noncontinuous clock with the information being transmitted to the AD7711/AD7713 in smaller batches of data. |
| MCLK IN | Master Clock signal for the device. This can be provided in the form of a crystal or external clock. A crystal can be tied across the MCLK IN and MCLK OUT pins. Alternatively, the MCLK IN pin can be driven with a CMOS-compatible clock and MCLK OUT left unconnected. The clock input frequency is nominally 2 MHz for AD7713 and 10 MHz for AD7711. |
| MCLK OUT | When the master clock for the device is a crystal, the crystal is connected between MCLK IN and MCLK OUT. |
| A0 | Address Input. With this input low, reading and writing to the device is to the control register. With this input high, access is to either the data register or the calibration registers. |
| SYNC | Logic Input which allows for synchronization of the digital filters when using a number of AD7711/AD7713s. It resets the nodes of the digital filter. |
| MODE | Logic Input. When this pin is high, the device is in its self-clocking mode; with this pin low, the device is in its external clocking mode. |
| AIN1(+) | Analog Input Channel 1. Positive input of the programmable-gain differential analog input. The AIN1 $(+)$ input is connected to an output current source which can be used to check that an external transducer has burnt out or has gone open circuit. This output current source can be turned on/off via the control register. |
| AIN1 | Analog Input Channel 1. Negative input of the programmable gain differential analog input. |
| AIN2 | AD7711 Only. Analog Input Channel 2. Single-ended programmable gain analog input. |
| REF OUT | AD7711 Only. Reference Output. The internal +2.5 V reference is provided at this pin. This is a single-ended output which is reference to AGND. It is a buffered output capable of providing 1 mA to an external load. |
| $\mathrm{V}_{\text {BIAS }}$ | AD7711 Only. Input Bias Voltage. This input voltage should be set such that $\mathrm{V}_{\text {BIAS }}+0.85 \times \mathrm{V}_{\mathrm{REF}}<\mathrm{AV}_{\mathrm{DD}}$ and $\mathrm{V}_{\text {BIAS }}-0.85 \times \mathrm{V}_{\mathrm{REF}}>\mathrm{V}_{\text {SS }}$ where $\mathrm{V}_{\mathrm{REF}}$ is REF IN( + ) - REF IN( - ). See $\mathrm{V}_{\text {BIAS }}$ input section. |
| $\mathrm{V}_{\text {ss }}$ | AD7711 Only. Analog Negative Supply, 0 V to -5 V . Tied to AGND for single supply operation. The input voltage on AIN1 or AIN2 should not go $>30 \mathrm{mV}$ negative w.r.t. $\mathrm{V}_{\text {Ss }}$ for correct operation of the device. |
| AIN2(+) | AD7713 Only. Analog Input Channel 2. Positive input of the programmable gain differential analog input. |
| AIN2(-) | AD7713 Only. Analog Input Channel 2. Negative input of the programmable gain differential analog input. |
| STANDBY | AD7713 Only. Logic Input. Taking this pin low shuts down the internal analog and digital circuitry, reducing power consumption to less than $50 \mu \mathrm{~W}$. |
| $\mathrm{AV}_{\text {L }}$ | Analog Positive Supply Voltage, +5 V to +10 V . |
| RTD1 | Constant Current Output. A nominal $200 \mu \mathrm{~A}$ constant current is provided at this pin and this can be used as the excitation current for RTDs. This, current can be turned on or off via the control register. |
| RTD2 | Constant Current Output. A nominal $200 \mu \mathrm{~A}$ constant current is provided at this pin and this can be used as the excitation current for RTDs. This current can be turned on or off via the control register. This second current can be used to eliminate lead resistance errors in three-wire RTD configurations. |
| REF IN(-) | Reference Input. The REF IN $(-)$ can lie anywhere between $\mathrm{AV}_{\text {DD }}$ and AGND provided REF IN $(+)$ is greater than REF IN(-). |
| REF IN(+) | Reference Input. The reference input is differential with the provision that REF IN $(+)$ must be greater than REF IN( - ). REF IN(+) can lie anywhere between AV $_{\text {DD }}$ and AGND. |
| AIN3 | AD7713 only. Analog Input Channel 3. High level analog input which accepts an analog input voltage range of $4 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}$. At the nominal $\mathrm{V}_{\mathrm{REF}}$ of +2.5 V and a gain of 1 , the AIN3 input voltage range is 0 to +10 V . |
| AGND | Ground Reference Point for Analog Circuitry. |
| $\overline{\mathrm{TFS}}$ | Transmit Frame Synchronization. Active low logic input used to write serial data to the device with serial data expected after the falling edge of this pulse. In the self-clocking mode, the serial clock becomes active after TFS goes low. In the external clocking mode, $\overline{\text { TFS }}$ must go low before the first bit of the data word is written to the part. |
| $\overline{\mathrm{RFS}}$ | Receive Frame Synchronization. Active low logic input used to access serial data from the device. In the self-clocking mode, the SCLK and SDATA lines both become active after $\overline{\mathrm{RFS}}$ goes low. In the external clocking mode, the SDATA line becomes active after $\overline{\mathrm{RFS}}$ goes low. |


| Mnemonic | Function |
| :---: | :---: |
| $\overline{\text { DRDY }}$ | Logic Output. A falling edge indicates a new output word is available for transmission. The $\overline{\mathrm{DRDY}}$ pin will return high upon completion of transmission of a full output word. $\overline{\mathrm{DRDY}}$ is also used to indicate when the AD7711/AD7713 has completed its on-chip calibration sequence. |
| SDATA | Serial Data. Input/Output with serial data being written to either the control register or the calibration registers and serial data being accessed from the control register, calibration registers or the data register. During an output data read operation, serial data becomes active after $\overline{\mathrm{RFS}}$ goes low (provided $\overline{\mathrm{DRDY}}$ is low). During a write operation, valid serial data is expected on the rising edges of SCLK when TFS is low. The output data is natural binary for unipolar inputs and offset binary for bipolar inputs. |
| DV ${ }_{\text {DD }}$ | Digital Supply Voltage, $+5 \mathrm{~V} . \mathrm{DV}_{\mathrm{DD}}$ should never exceed $\mathrm{AV}_{\mathrm{DD}}$ by more than 0.3 V . If $\mathrm{DV}_{\mathrm{DD}}$ powers up before $A V_{D D}$ or if $D V_{D D}$ can exceed $A V_{D D}$ by more than 0.3 V at any other time, the protection scheme outlined in Figure 5 should be used. |
| DGND | Ground Reference Point for Digital Circuitry. |

## TERMINOLOGY

## INTEGRAL NONLINEARITY

This is the maximum deviation of any code from a straight line passing through the endpoints of the transfer function. The endpoints of the transfer function are zero scale (not to be confused with bipolar zero), a point 0.5 LSB below the first code transition ( $000 \ldots 000$ to $000 \ldots 001$ ) and full scale, a point 0.5 LSB above the last code transition (111 . . . 110 to 111 . . . 111). The error is expressed as a percentage of full scale.

## POSITIVE FULL-SCALE ERROR

Positive full-scale error is the deviation of the last code transition (111 . . . 110 to $111 \ldots$. 111) from the ideal input full-scale voltage. For AIN(+), the ideal full-scale input voltage is (AIN (-) $+\mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}-3 / 2 \mathrm{LSBs}$ ); for AIN2 of AD7711, the ideal full-scale input voltage is $\mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}-3 / 2 \mathrm{LSBs}$; for AIN3 of AD7713, the ideal full-scale voltage is $+4 \times \mathrm{V}_{\mathrm{REF}} /$ GAIN - $3 / 2$ LSBs. Positive full-scale error applies to both unipolar and bipolar analog input ranges.

## UNIPOLAR OFFSET ERROR

Unipolar offset error is the deviation of the first code transition from the ideal input voltage. For AIN( + ), the ideal input voltage is (AIN $(-)+0.5$ LSB); for AIN2 of AD7711 and AIN3 of AD7713, the ideal input is 0.5 LSB when operating in the Unipolar Mode.

## BIPOLAR ZERO ERROR

This is the deviation of the midscale transition ( 0111 . . . 111 to 1000 . . . 000) from the ideal input voltage. For AIN( + ), the ideal input voltage is (AIN(-) - 0.5 LSB); for AIN2 of AD7711 the ideal input is -0.5 LSB ; AIN3 of AD7713 can only accommodate unipolar input ranges.

## BIPOLAR NEGATIVE FULL-SCALE ERROR

This is the deviation of the first code transition from the ideal input voltage. For AIN( + ), the ideal input voltage is (AIN(-) $\left.-\mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}+0.5 \mathrm{LSB}\right)$; for AIN2 of AD7711 the ideal input is $-\mathrm{V}_{\text {REF }} / \mathrm{GAIN}$ to 0.5 LSB when operating from dual supplies; AIN3 of AD7713 can only accommodate unipolar input ranges.

## POSITIVE FULL-SCALE OVERRANGE

Positive full-scale overrange is the amount of overhead available to handle input voltages on the $\operatorname{AIN}(+)$ inputs greater than (AIN(-) $+\mathrm{V}_{\mathrm{REF}} /$ GAIN ) or on AIN2 of AD7711 of greater than $\mathrm{V}_{\text {REF }} /$ GAIN or AIN3 of AD7713 of greater than $+4 \times \mathrm{V}_{\mathrm{REF}} /$ GAIN (for example, noise peaks or excess voltages due to system gain errors in system calibration routines) without introducing errors due to overloading the analog modulator or to overflowing the digital filter.

## NEGATIVE FULL-SCALE OVERRANGE

This is the amount of overhead available to handle voltages on AIN $(+)$ below (AIN( - ) - $\mathrm{V}_{\mathrm{REF}} /$ GAIN) or on AIN2 of AD7711 below $-\mathrm{V}_{\mathrm{REF}}$ /GAIN without overloading the analog modulator or overflowing the digital filter.

## OFFSET CALIBRATION RANGE

In the system calibration modes, the AD7711/AD7713 calibrates its offset with respect to the analog input. The offset calibration range specification defines the range of voltages that the AD7711/AD7713 can accept and still calibrate offset accurately.

## FULL-SCALE CALIBRATION RANGE

This is the range of voltages that the AD7711/AD7713 can accept in the system calibration mode and still calibrate full scale correctly.

## INPUT SPAN

In system calibration schemes, two voltages applied in sequence to the AD7711/AD7713's analog input define the analog input range. The input span specification defines the minimum and maximum input voltages from zero to full scale that the AD7711/AD7713 can accept and still calibrate gain accurately.

## Control Register (24 Bits)

A write to the device with the A0 input low writes data to the control register. A read to the device with the A0 input low accesses the contents of the control register. The control register is 24 -bits wide and when writing to the register 24 bits of data must be written otherwise the data will not be loaded to the control register. In other words, it is not possible to write just the first 12 bits of data into the control register. If more than 24 clock pulses are provided before TFS returns high, then all clock pulses after the 24th clock pulse are ignored. Similarly, a read operation from the control register should access 24 bits of data.
MSB

| MD2 | MD1 | MD0 | G2 | G1 | G0 | S1 $^{1}$ | S $2^{2}$ | WL | RO | BO | B/U |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| FS11 | FS10 | FS9 | FS8 | FS7 | FS6 | FS5 | FS4 | FS3 | FS2 | FS1 | FS0 |

## NOTES

${ }^{1}$ On the AD7711 this bit is CH , and on the AD7713 this bit is CH 1 .
${ }^{2}$ On the AD7711 this bit is PD, and on the AD7713 this bit is CH0.

| Operating Mode |  |  |  |
| :---: | :---: | :---: | :---: |
| MD2 | MD1 | MD0 | Operating Mode |
| 0 | 0 | 0 | Normal Mode. This is the normal mode of operation of the device whereby a read to the device with A0 high accesses data from the data register. This is the default condition of these bits after the internal power-on reset. |
| 0 | 0 | 1 | Activate Self-Calibration. This activates self-calibration on the channel selected by $\mathrm{CH}(\mathrm{CH} 0$ and CH 1 on AD7713). This is a one-step calibration sequence, and when complete, the part returns to Normal Mode (with MD2, MD1, MD0 of the control register returning to $0,0,0$ ). The $\overline{\mathrm{DRDY}}$ line indicated when this self-calibration is complete and valid data is available in the output register. For this calibration type, the zero-scale calibration is done internally on shorted (zeroed) inputs and the full-scale calibration is done internally on $\mathrm{V}_{\mathrm{REF}}$. |
| 0 | 1 | 0 | Activate System Calibration. This activates system calibration on the channel selected by $\mathrm{CH}(\mathrm{CH} 0$ and CH 1 on AD7713). This is a two-step calibration sequence, with the zero-scale calibration done first on the selected input channel and $\overline{\text { DRDY }}$ indicating when this zero-scale calibration is complete. The part returns to Normal Mode at the end of this first step in the two-step sequence. |
| 0 | 1 | 1 | Activate System Calibration. This is the second step of the system calibration sequence with full-scale calibration being performed on the selected input channel. Once again, $\overline{\mathrm{DRDY}}$ indicated when this fullscale calibration is complete. When this calibration is complete, the part returns to Normal Mode. |
| 1 | 0 | 0 | Activate System-Offset Calibration. This activates system-offset calibration on the channel selected by CH ( CH 0 and CH 1 on AD7713). This is a one step calibration sequence and when complete the part returns to Normal Mode with $\overline{\text { DRDY }}$ indicating when this system offset calibration is complete. For this calibration type, the zero-scale calibration is done on the selected input channel and the full-scale calibration is done internally on $\mathrm{V}_{\mathrm{REF}}$. |
| 1 | 0 | 1 | Activate Background Calibration. This activates background calibration on the channel selected by CH (CH0 and CH1 on AD7713). If the background calibration mode is on, then the AD7711/AD7713 provides continuous self-calibration of the reference and shorted (zeroed) inputs. This calibration takes place as part of the conversion sequence, extending the conversion time and reducing the word rate by a factor of six. Its major advantage is that the user does not have to worry about recalibrating the device when there is a change in the ambient temperature. In this mode, shorted (zeroed) inputs and $\mathrm{V}_{\mathrm{REF}}$, as well as the analog input voltage, are continuously monitored and the calibration registers of the device are updated. |
| 1 | 1 | 0 | Read/Write Zero-Scale Calibration Coefficients. A read to the device with A0 high accesses the contents of the zero-scale calibration coefficients of the channel selected by CH ( CH 0 and $\mathrm{CH1}$ on AD7713). A write to the device with A0 high writes data to the zero-scale calibration coefficients of the channel selected by CH. The word length for reading and writing these coefficients is 24 bits, regardless of the status of the WL bit of the control register. Therefore, when writing to the calibration register, 24 bits of data must be written, otherwise the new data will not be transferred to the calibration register. |
| 1 | 1 | 1 | Read/Write Full-Scale Calibration Coefficients. A read to the device with A0 high accesses the contents of the full-scale calibration coefficients of the channel selected by CH ( CH 0 and CH 1 on AD7713). A write to the device with A0 high writes data to the full-scale calibration coefficients of the channel selected by CH. The word length for reading and writing these coefficients is 24 bits, regardless of the status of the WL bit of the control register. Therefore, when writing to the calibration register, 24 bits of data must be written, otherwise, the new data will not be transferred to the calibration register. |


| PGA Gain |  |  |  |
| :--- | :--- | :--- | :--- |
| G2 | G1 | G0 | Gain |
| 0 | 0 | 0 | 1 |
| 0 | 0 | 1 | 2 |
| 0 | 1 | 0 | 4 |
| 0 | 1 | 1 | 8 |
| 1 | 0 | 0 | 16 |
| 1 | 0 | 1 | 32 |
| 1 | 1 | 0 | 64 |
| 1 | 1 | 1 | 128 |


| Channel Selection |  |  |  |
| :--- | :--- | :--- | :--- |
| CH1 (AD7713 Only) | CH0 | Channel |  |
| 0 | 0 | AIN1 | (Default Condition After the Internal Power-On Reset) |
| 0 | 1 | AIN2 |  |
| 1 | 0 | AIN3 | AD7713 Only |

## Power-Down (AD7711 Only)

## PD

0 Normal Operation (Default Condition After Internal Power-On Reset)
1 Power-Down

## Word Length

WL Output Word Length
$\begin{array}{ll}0 & \text { 16-Bit } \\ 1 & \text { 24-Bit }\end{array}$

## RTD Excitation Currents

RO
0 Off (Default Condition After Internal Power-On Reset)

## Burn-Out Current

BO
$0 \quad$ Off $\quad$ (Default Condition After Internal Power-On Reset)

Bipolar/Unipolar Selection (Both Inputs)
B/U
0 Bipolar (Default Condition After Internal Power-On Reset)
1 Unipolar

## Filter Selection (FS11-FS0)

The on-chip digital filter provides a $\operatorname{Sinc}^{3}\left(\operatorname{or}(\operatorname{Sin} x / x)^{3}\right)$ filter response. The 12 bits of data programmed into these bits determine the filter cutoff frequency, the position of the first notch of the filter and the data rate for the part. In association with the gain selection, it also determines the output noise (and hence the effective resolution) of the device.

The first notch of the filter occurs at a frequency determined by the relationship: filter first notch frequency $=\left(\mathrm{f}_{\mathrm{CLK}} \mathrm{iN} / 512\right) /$ code where code is the decimal equivalent of the code in bits FS0 to FS11 and is in the range 19 to 2,000. The value of the code loaded to these bits must be within this range. Failure to do this will result in unspecified operation of the device.

Changing the filter notch frequency, as well as the selected gain, impacts resolution. Tables I and II show the effect of the filter notch frequency and gain on the effective resolution of the part. The output data rate (or effective conversion time) for the device is equal to the frequency selected for the first notch of the filter. For example, if the first notch of the filter is at 10 Hz then a new word is available at a 10 Hz rate or every 100 ms . If the first notch is at 200 Hz , a new word is available every 5 ms .
The settling time of the filter to a full-scale step input change is worst case $4 \times 1 /$ (the output data rate). This settling time is to $100 \%$ of the final value. For example, with the first filter notch at 10 Hz , the settling time of the filter to a full-scale step input change is 400 ms max. This settling time can be reduced to $3 \times 1 /$ (output data rate) by synchronizing the step input change to a reset of the digital filter. In other words, if the step input takes place with $\overline{S Y N C}$ low, the settling time will be $3 \times 1 /$ (output data rate). If a change of channel takes place, the settling time is $3 \times 1$ (output data rate) regardless of the $\overline{\text { SYNC input, but } \overline{\text { DRDY }} \text { does not stay }}$ high for $3 \times 1$ /output rate. The -3 dB frequency is determined by the programmed first notch frequency according to the relationship: filter -3 dB frequency $=0.262 \times$ first notch frequency.

Tables I and II show the output rms noise for some typical notch and -3 dB frequencies for the AD7711. The numbers given are for the bipolar input ranges with a $\mathrm{V}_{\mathrm{REF}}$ of +2.5 V . These numbers are typical and are generated with an analog input voltage of 0 V . The output noise from the part comes from two sources. The first is the electrical noise in the semiconductor devices used in the implementation of the modulator (device noise). The second occurs when the analog input signal is converted into the digital domain adding quantization noise. The device noise is at a low level and is largely independent of frequency. The quantization noise starts at an even lower level but rises rapidly with increasing frequency to become the dominant noise source. Consequently, lower filter notch settings (below 60 Hz approximately) tend to be device noise dominated while higher notch settings are dominated by quantization noise. Changing the filter notch and cutoff frequency in the quantization noise dominated region results in a more dramatic improvement in noise performance than it does in the device noise dominated region as shown in Table I. Furthermore, quantization noise is added after the PGA, so effective resolution is independent of gain for the higher filter notch frequencies. Meanwhile, device noise is added in the PGA and, therefore, effective resolution suffers a little at high gains for lower notch frequencies.
At the lower filter notch settings (below 60 Hz ), the no missing codes performance of the device is at the 24-bit level. At the higher settings, more codes will be missed until at 1 kHz notch setting, no missing codes performance is only guaranteed to the 12 -bit level. However, since the effective resolution of the part is 10.5 bits for this filter notch setting, this no missing codes performance should be more than adequate for all applications.
The effective resolution of the device is defined as the ratio of the output rms noise to the input full scale. This does not remain constant with increasing gain or with increasing bandwidth. Table II shows the same table as Table I except that the output is now . expressed in terms of effective resolution (the magnitude of the rms noise with respect to $2 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}$, i.e., the input full scale). It is possible to do post filtering on the device to improve the output data rate for a given -3 dB frequency and also to further reduce the output noise (see Digital Filtering section).

Table I. Output Noise vs. Gain and First Notch Frequency for AD7711

| First Notch of Filter and O/P Data Rate ${ }^{1}$ | $-3 \mathrm{~dB}$ <br> Frequency | Typical Output RMS Noise ( $\mu \mathrm{V}$ ) |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Gain of 1 | Gain of 2 | Gain of 4 | Gain of 8 | Gain of 16 | Gain of 32 | Gain of 64 | Gain of 128 |
| $10 \mathrm{~Hz}^{2}$ | 2.62 Hz | 1.7 | 1.0 | 0.5 | 0.36 | 0.36 | 0.36 | 0.36 | 0.36 |
| $25 \mathrm{~Hz}^{2}$ | 6.55 Hz | 4.9 | 2.2 | 1.2 | 0.6 | 0.36 | 0.36 | 0.36 | 0.36 |
| $30 \mathrm{~Hz}^{2}$ | 7.86 Hz | 6.1 | 2.4 | 1.2 | 0.84 | 0.5 | 0.36 | 0.36 | 0.36 |
| $50 \mathrm{~Hz}^{2}$ | 13.1 Hz | 7.5 | 3.8 | 2.0 | 1.0 | 0.6 | 0.5 | 0.5 | 0.45 |
| $60 \mathrm{~Hz}^{2}$ | 15.72 Hz | 8.5 | 4.0 | 2.0 | 1.0 | 0.6 | 0.5 | 0.5 | 0.45 |
| $100 \mathrm{~Hz}^{3}$ | 26.2 Hz | 13 | 6.4 | 3.7 | 1.8 | 1.1 | 0.9 | 0.65 | 0.65 |
| $250 \mathrm{~Hz}^{3}$ | 65.5 Hz | 130 | 75 | 25 | 12 | 7.5 | 4 | 2.7 | 1.7 |
| $500 \mathrm{~Hz}^{3}$ | 131 Hz | $0.6 \times 10^{3}$ | $0.26 \times 10^{3}$ | 140 | 70 | 35 | 25 | 15 | 8 |
| $1 \mathrm{kHz}^{3}$ | 262 Hz | $3.1 \times 10^{3}$ | $1.6 \times 10^{3}$ | $0.7 \times 10^{3}$ | $0.29 \times 10^{3}$ | 180 | 120 | 70 | 40 |

## NOTES

${ }_{2}^{1}$ The default condition (after the internal power-on reset) for the first notch of filter is 60 Hz .
${ }^{2}$ For these filter notch frequencies, the output rms noise is primarily dominated by device noise and as a result is independent of the value of the reference voltage. Therefore, increasing the reference voltage will give an increase in the effective resolution of the device (i.e., the ratio of the rms noise to the input full scale is increased since the output rms noise remains constant as the input full scale increases).
${ }^{3}$ For these filter notch frequencies, the output rms noise is dominated by quantization noise and as a result is proportional to the value of the reference voltage.
Table II. Effective Resolution vs. Gain and First Notch Frequency for AD7711

| First Notch of Filter and O/P Data Rate | $-3 \mathrm{~dB}$ <br> Frequency | Effective Resolution ${ }^{1}$ (Bits) |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Gain of 1 | Gain of 2 | Gain of 4 | Gain of 8 | Gain of 16 | Gain of 32 | Gain of 64 | Gain of 128 |
| 10 Hz | 2.62 Hz | 21.5 | 21.5 | 21.5 | 20.5 | 19.5 | 18.5 | 17.5 | 16.5 |
| 25 Hz | 6.55 Hz | 20 | 20 | 20 | 20 | 19.5 | 18.5 | 17.5 | 16.5 |
| 30 Hz | 7.86 Hz | 19.5 | 20 | 20 | 19.5 | 19.5 | 18.5 | 17.5 | 16.5 |
| 50 Hz | 13.1 Hz | 19.5 | 19.5 | 19.5 | 19.5 | 19 | 18.5 | 17.5 | 16.5 |
| 60 Hz | 15.72 Hz | 19 | 19.5 | 19.5 | 19.5 | 19 | 18.5 | 17.5 | 16.5 |
| 100 Hz | 26.2 Hz | 18.5 | 18.5 | 18.5 | 18.5 | 18 | 17.5 | 17 | 16 |
| 250 Hz | 65.5 Hz | 15 | 15 | 15.5 | 15.5 | 15.5 | 15.5 | 15 | 14.5 |
| 500 Hz | 131 Hz | 13 | 13 | 13 | 13 | 13 | 12.5 | 12.5 | 12.5 |
| 1 kHz | 262 Hz | 10.5 | 10.5 | 11 | 11 | 11 | 10.5 | 10 | 10 |

[^34]
## AD7711/AD7713

Tables Ia and IIa show the output rms noise for some typical notch and -3 dB frequencies for the AD7713. The numbers given are for the bipolar input ranges with a $\mathrm{V}_{\mathrm{REF}}$ of +2.5 V . These numbers are typical and are generated with an analog input voltage of 0 V . The output noise from the part comes from two sources. Firstly, there is the electrical noise in the semiconductor devices used in the implementation of the modulator (device noise). Secondly, when the analog input signal is converted into the digital domain, quantization noise is added. The device noise is at a low level and is largely independent of frequency. The quantization noise starts at an even lower level but rises rapidly with increasing frequency to become the dominant noise source. Consequently, lower filter notch settings (below 12 Hz approximately) tend to be device noise dominated while higher notch settings are dominated by quantization noise. Changing the filter notch and cutoff frequency in the quantization-noise dominated region results in a more dramatic improvement in noise performance than it does in the device-noise dominated region as shown in Table Ia. Furthermore, quantization noise is added after the PGA, so effective resolution is independent of gain for the higher filter notch frequencies. Meanwhile, device noise is added in the PGA and, therefore, effective resolution suffers a little at high gains for lower notch frequencies.
At the lower filter notch settings (below 12 Hz ), the no missing codes performance of the device is at the 24 -bit level. At the higher settings, more codes will be missed until at 200 Hz notch setting, no missing codes performance is only guaranteed to the 12 -bit level. However, since the effective resolution of the part is 10.5 bits for this filter notch setting, this no missing codes performance should be more than adequate for all applications.
The effective resolution of the device is defined as the ratio of the output rms noise to the input full scale. This does not remain constant with increasing gain or with increasing bandwidth. Table IIa shows the same table as Table Ia except that the output is now expressed in terms of effective resolution (the magnitude of the rms noise with respect to $2 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}$, i.e., the input full scale). It is possible to do post filtering on the device to improve the output data rate for a given -3 dB frequency and also to further reduce the output noise (see Digital Filtering section).

Table Ia. Output Noise vs. Gain and First Notch Frequency for AD7713

| First Notch of Filter and O/P Data Rate ${ }^{1}$ | $-3 \mathrm{~dB}$ <br> Frequency | Typical Output RMS Noise ( $\mu \mathrm{V}$ ) |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Gain of 1 | Gain of 2 | Gain of 4 | Gain of 8 | Gain of 16 | Gain of 32 | Gain of 64 | Gain of 128 |
| $2 \mathrm{~Hz}^{2}$ | 0.52 Hz | 1.7 | 1.0 | 0.5 | 0.36 | 0.36 | 0.36 | 0.36 | 0.36 |
| $5 \mathrm{~Hz}^{2}$ | 1.31 Hz | 4.9 | 2.2 | 1.2 | 0.6 | 0.36 | 0.36 | 0.36 | 0.36 |
| $6 \mathrm{~Hz}^{2}$ | 1.57 Hz | 6.1 | 2.4 | 1.2 | 0.84 | 0.5 | 0.36 | 0.36 | 0.36 |
| $10 \mathrm{~Hz}^{2}$ | 2.62 Hz | 7.5 | 3.8 | 2.0 | 1.0 | 0.6 | 0.5 | 0.5 | 0.45 |
| $12 \mathrm{~Hz}^{2}$ | 3.14 Hz | 8.5 | 4.0 | 2.0 | 1.0 | 0.6 | 0.5 | 0.5 | 0.45 |
| $20 \mathrm{~Hz}^{3}$ | 5.24 Hz | 13 | 6.4 | 3.7 | 1.8 | 1.1 | 0.9 | 0.65 | 0.65 |
| $50 \mathrm{~Hz}^{3}$ | 13.1 Hz | 130 | 75 | 25 | 12 | 7.5 | 4 | 2.7 | 1.7 |
| $100 \mathrm{~Hz}^{3}$ | 26.2 Hz | $0.6 \times 10^{3}$ | $0.26 \times 10^{3}$ | 140 | 70 | 35 | 25 | 15 | 8 |
| $200 \mathrm{~Hz}^{3}$ | 52.4 Hz | $3.1 \times 10^{3}$ | $1.6 \times 10^{3}$ | $0.7 \times 10^{3}$ | $0.29 \times 10^{3}$ | 180 | 120 | 70 | 40 |

NOTES
${ }^{1}$ The default condition (after the internal power-on reset) for the first notch of filter is 12 Hz .
${ }^{2}$ For these filter notch frequencies, the output rms noise is primarily dominated by device noise and a result is independently of the value of the reference voltage. Therefore, increasing the reference voltage will give an increase in the effective resolution of the device (i.e., the ratio of the rms noise to the input full scale is increased since the output rms noise remains constant as the input full-scale increases).
${ }^{3}$ For these filter notch frequencies, the output rms noise is dominated by quantization noise and as a result is proportional to the value of the reference voltage.
Table IIa. Effective Resolution vs. Gain and First Notch Frequency for AD7713

| First Notch of Filter and O/P Data Rate | $-3 \mathrm{~dB}$ <br> Frequency | Effective Resolution ${ }^{1}$ (Bits) |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Gain of 1 | Gain of 2 | Gain of 4 | Gain of 8 | Gain of 16 | Gain of 32 | Gain of 64 | Gain of 128 |
| 2 Hz | 0.52 Hz | 21.5 | 21.5 | 21.5 | 20.5 | 19.5 | 18.5 | 17.5 | 16.5 |
| 5 Hz | 1.31 Hz | 20 | 20 | 20 | 20 | 19.5 | 18.5 | 17.5 | 16.5 |
| 6 Hz | 1.57 Hz | 19.5 | 20 | 20 | 19.5 | 19.5 | 18.5 | 17.5 | 16.5 |
| 10 Hz | 2.62 Hz | 19.5 | 19.5 | 19.5 | 19.5 | 19 | 18.5 | 17.5 | 16.5 |
| 12 Hz | 3.14 Hz | 19 | 19.5 | 19.5 | 19.5 | 19 | 18.5 | 17.5 | 16.5 |
| 20 Hz | 5.24 Hz | 18.5 | 18.5 | 18.5 | 18.5 | 18 | 17.5 | 17 | 16 |
| 50 Hz | 13.1 Hz | 15 | 15 | 15.5 | 15.5 | 15.5 | 15.5 | 15 | 14.5 |
| 100 Hz | 26.2 Hz | 13 | 13 | 13 | 13 | 13 | 12.5 | 12.5 | 12.5 |
| 200 Hz | 52.4 Hz | 10.5 | 10.5 | 11 | 11 | 11 | 10.5 | 10 | 10 |

[^35]
## CIRCUIT DESCRIPTION

The AD7711/AD7713 is a sigma-delta A/D converter with on-chip digital filtering, intended for the measurement of wide dynamic range, low frequency signals such as those in industrial control or process control applications. It contains a sigma-delta (or charge-balancing) ADC, a calibration microcontroller with on-chip static RAM, a clock oscillator, a digital filter and a bidirectional serial communications port.
The AD7711 contains two programmable gain input channels, one differential and one single-ended. The AD7713 contains three programmable gain analog input channels, two differential input and one high-level single-ended input. The gain range on all inputs is from 1 to 128 . For the low-level inputs, this means that the input can accept unipolar signals of between 0 mV to +20 mV and 0 V to +2.5 V or bipolar signals in the range from $\pm 20 \mathrm{mV}$ to $\pm 2.5 \mathrm{~V}$ when the reference input voltage equals +2.5 V . The input voltage range for the AIN3 of the AD7713 input is $+4 \times \mathrm{V}_{\text {REF }} / \mathrm{GAIN}$ and is 0 V to +10 V with the nominal reference of +2.5 V and a gain of 1 . The input signal to the selected analog input channel is continuously sampled at a rate determined by the frequency of the master clock, CLK IN, and the selected gain (see Table III). A charge balancing A/D converter (Sigma-Delta Modulator) converts the sampled signal into a digital pulse train whose duty cycle contains the digital information. The programmable gain function on the analog input is also incorporated in this sigma-delta modulator with the input sampling frequency being modified to give the higher gains. A $\operatorname{sinc}^{3}$ digital low-pass filter processes the output of the sigmadelta modulator and updates the output register at a rate determined by the first notch frequency of this filter. The output data can be read from the serial port randomly or periodically at any rate up to the output register update rate. The first notch of this digital filter (and hence its -3 dB frequency) can be programmed via an on-chip control register.
The AD7711/AD7713 provides a number of calibration options which can be programmed via the on-chip control register. A calibration cycle may be initiated at any time by writing to this control register. The part can perform self-calibration using the on-chip calibration microcontroller and SRAM to store calibration parameters. Other system components may also be included in the calibration loop to remove offset and gain errors in the input channel using the system calibration mode. Another option is a background calibration mode where the part continuously performs self-calibration and updates the calibration coefficients. Once the part is in this mode, the user does not have to worry about issuing periodic calibration commands to the device or asking the device to recalibrate when there is a change in the ambient temperature or power supply voltage.
The AD7711/AD7713 gives the user access to the on-chip calibration registers allowing the microprocessor to read the device's calibration coefficients and also to write its own calibration coefficients to the part from prestored values in $E^{2}$ PROM. This gives the microprocessor much greater control over the part's calibration procedure. It also means that the user can verify that the device has performed its calibration correctly by comparing the coefficients after calibration with prestored values in $E^{2}$ PROM. The AD7713 is a positive supply only part while the AD7711 can be operated from positive and negative supplies. For battery operation or low power systems, both parts offer a standby mode that reduces idle power consumption to $300 \mu \mathrm{~W}$ typical on AD7713 and 7 mW typical on the AD7711.

The AD7711/AD7713 uses a second-order sigma-delta modulator and a digital filter that provides a rolling average of the sampled output. After power-up or if there is a step change in the input voltage, there is a settling time that must elapse before valid data is obtained.

## Input Sample Rate

The modulator sample frequency for the device remains at $\mathrm{f}_{\mathrm{CLK} \text { IN }} / 512\left(3.9 \mathrm{kHz} @ \mathrm{f}_{\text {CLK IN }}=2 \mathrm{MHz}\right.$ and $19.5 \mathrm{kHz} @$ $\mathrm{f}_{\mathrm{CLKIN}}=10 \mathrm{MHz}$ ) regardless of the selected gain. However, gains greater than $\times 1$ are achieved by a combination of multiple input samples per modulator cycle and a scaling of the ratio of reference capacitor to input capacitor. As a result of the multiple sampling, the input sample rate of the device varies with the selected gain (see Table III). The effective input impedance is $1 / C \cdot f_{S}$ where $C$ is the input sampling capacitance and $f_{S}$ is the input sample rate.

Table III. Input Sampling Frequency vs. Gain

| Gain | Input Sampling Frequency $\left(\mathbf{f}_{\mathbf{s}}\right)$ |
| :--- | :--- |
| 1 | $\mathrm{f}_{\mathrm{CLK} \mathrm{IN}} / 512$ |
| 2 | $2 \times \mathrm{f}_{\mathrm{CLK} \mathrm{IN}} / 512$ |
| 4 | $4 \times \mathrm{f}_{\mathrm{CLK} \mathrm{IN}} / 512$ |
| 8 | $8 \times \mathrm{f}_{\mathrm{CLK} \mathrm{IN}} / 512$ |
| 16 | $8 \times \mathrm{f}_{\mathrm{CLK} \mathrm{IN}} / 512$ |
| 32 | $8 \times \mathrm{f}_{\mathrm{CLK} \mathrm{IN}} / 512$ |
| 64 | $8 \times \mathrm{f}_{\mathrm{CLK} \mathrm{IN}} / 512$ |
| 128 | $8 \times \mathrm{f}_{\mathrm{CLK} \mathrm{IN}} / 512$ |

DIGITAL FILTERING
The part's digital filter behaves like a similar analog filter, with a few minor differences.
First, since digital filtering occurs after the A-to-D conversion process, it can remove noise injected during the conversion process. Analog filtering cannot do this.
On the other hand, analog filtering can remove noise superimposed on the analog signal before it reaches the ADC. Digital filtering cannot do this and noise peaks riding on signals near full scale have the potential to saturate the analog modulator and digital filter, even though the average value of the signal is within limits. To alleviate this problem, the part has over-range headroom built into the sigma-delta modulator and digital filter which allows overrange excursions of $5 \%$ above the analog input range. If noise signals are larger than this, consideration should be given to analog input filtering, or to reducing the input channel voltage so that its full scale is half that of the analog input channel full scale. This will provide an overrange capability greater than $100 \%$ at the expense of reducing the dynamic range by 1 bit ( $50 \%$ ).

## Filter Characteristics

The cutoff frequency of the digital filter is determined by the value loaded to bits FS0 to FS11 in the control register. At a clock frequency of 2 MHz , the minimum cutoff frequency of the filter is 0.52 Hz while the maximum programmable cutoff frequency is 53.9 Hz . At a clock frequency of 10 MHz (AD7711 only), the minimum cutoff frequency of the filter is 2.58 Hz while the maximum programmable cutoff frequency is 269 Hz .
Figure 2 shows the filter frequency response for a cutoff frequency of 2.62 Hz which corresponds to a first filter notch frequency of 10 Hz . This is a $(\sin \mathrm{x} / \mathrm{x})^{3}$ response (also called $\operatorname{sinc}^{3}$ ) that provides $>100 \mathrm{~dB}$ of 50 Hz and 60 Hz rejection. Programming a different cutoff frequency via FS0-FS11 does not alter
the profile of the filter response, it changes the frequency of the notches as outlined in the Control Register section.


Figure 2. Frequency Response of AD7711/AD7713 Filter
Since the AD7711/AD7713 contains this on-chip, low-pass filtering, there is a settling time associated with step function inputs and data on the output will be invalid after a step change until the settling time has elapsed. The settling time depends upon the notch frequency chosen for the filter. The output data rate equates to this filter notch frequency and the settling time of the filter to a full-scale step input is 4 times the output data period. In applications using both input channels, the settling time of the filter must be allowed to elapse before data from the second channel is accessed.

## Post Filtering

The on-chip modulator provides samples at a 3.9 kHz output rate ( 2 MHz clock) and 19.5 kHz ( 10 MHz clock). The on-chip digital filter decimates these samples to provide data at an output rate which corresponds to the programmed first notch frequency of the filter. Since the output data rate exceeds the Nyquist criterion, the output rate for a given bandwidth will satisfy most application requirements. However, there may be some applications which require a higher data rate for a given bandwidth and noise performance. Applications which need this higher data rate will require some post filtering following the digital filter of the AD7711/AD7713.
For example, if the required bandwidth is 7.86 Hz but the required update rate is 100 Hz , the data can be taken from the AD7711/AD7713 at the 100 Hz rate giving a -3 dB bandwidth of 26.2 Hz . Post filtering can be applied to this to reduce the bandwidth and output noise, to the 7.86 Hz bandwidth level, while maintaining an output rate of 100 Hz .
Post filtering can also be used to reduce the output noise from the device for low bandwidths. Noise in these bandwidths is essentially device noise or white noise, and since the input is chopped, the noise has a flat frequency response. By reducing the bandwidth, the noise in the resultant passband can be reduced. A reduction in bandwidth by a factor of 2 results in a $\sqrt{2}$ reduction in the output rms noise. This additional filtering will result in a longer settling time.

## Antialias Considerations

The digital filter does not provide any rejection at integer multiples of the modulator sample frequency. This means that there are frequency bands, $\pm f_{3} \mathrm{~dB}$ wide ( $\mathrm{f}_{3 \mathrm{~dB}}$ is cutoff frequency
selected by FS0 to FS11) where noise passes unattenuated to the output. However, due to the part's high oversampling ratio, these bands occupy only a small fraction of the spectrum and most broadband noise is filtered. In any case, because of the high oversampling ratio a simple, RC, single-pole filter is generally sufficient to attenuate the signals in these bands on the ana$\log$ input and thus provide adequate antialiasing filtering.
If passive components are placed in front of the AIN1 and AIN2 inputs of the AD7711/AD7713, care must be taken to ensure that the source impedance is low enough so as not to introduce gain errors in the system. The dc input impedance for the AIN1 and AIN2 inputs is over $1 \mathrm{G} \Omega$. The input appears as a dynamic load which varies with the clock frequency and with the selected gain (see Figure 3). The input sample rate, as shown in Table III, determines the time allowed for the analog input capacitor, $\mathrm{C}_{\mathrm{IN}}$, to be charged. External impedances result in a longer charge time for this capacitor and this may result in gain errors being introduced on the analog inputs. Both inputs of the differential input channels look into similar input circuitry.
In any case, the error introduced due to longer charging times is a gain error which can be removed using the system calibration capabilities of the AD7711/AD7713 provided that the resultant span is within the span limits of the system calibration techniques for the AD7711/AD7713.


Figure 3. AIN1, AIN2 Input Impedance
The AIN3 input of the AD7713 contains a resistive attenuation network as outlined in Figure 4. The typical input impedance on this input is $44 \mathrm{k} \Omega$. As a result, the AIN3 input of the AD7713 should be driven from a low impedance source.


Figure 4. AIN3 Input Impedance

## ANALOG INPUT FUNCTIONS

 Analog Input RangesBoth analog inputs on the AD7711 are programmable-gain, input channels which can handle either unipolar or bipolar input signals. The AIN1 channel of the AD7711 is a differential input channel having a common-mode range from $\mathrm{V}_{\text {SS }}$ to $\mathrm{AV}_{\mathrm{DD}}$, provided that the absolute value of the analog input voltage lies between $\mathrm{V}_{\mathrm{ss}}-30 \mathrm{mV}$ and $\mathrm{AV}_{\mathrm{DD}}+30 \mathrm{mV}$. The AIN2 input channel is a single-ended input that is referred to AGND.
The analog inputs on the AD7713 provide the user with considerable flexibility in terms of analog input voltage ranges. Two of the inputs are differential, programmable-gain, input channels which can handle either unipolar or bipolar input signals. The common-mode range of these inputs is from AGND to $\mathrm{AV}_{\mathrm{DD}}$
provided that the absolute value of the analog input voltage lies between AGND -30 mV and $\mathrm{AV}_{\mathrm{DD}}+30 \mathrm{mV}$. The third analog input is a single-ended, programmable gain high-level input which accepts analog input ranges of 0 to $+4 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}$.
The dc input leakage current on the AIN1 and AIN2 inputs is 10 pA maximum at $25^{\circ} \mathrm{C}( \pm 1 \mathrm{nA}$ over temperature $)$. This results in a dc offset voltage developed across the source impedance. However, this dc offset effect can be compensated for by a combination of the differential input capability of the part and its. system calibration mode. The dc input current on the AIN3 of the AD7713 input depends on the input voltage, For the nominal input voltage range of +10 V , the input current is $225 \mu \mathrm{~A}$ typ.

## Burn Out Current

The AIN1(+) input of the AD7711/AD7713 contains a current source which can be turned on/off via the control register. This current source can be used in checking that a transducer has not burnt out or gone open circuit before attempting to take measurements on that channel. If the current is turned on and is allowed flow into the transducer and a measurement of the input voltage on the AIN1 input is taken, it can indicate that the transducer is not functioning correctly. For normal operation, this burn out current is turned off by writing a 0 to the BO bit in the control register. The burn-out current is $1 \mu \mathrm{~A}$ for the AD7711 and 200 nA for the AD7713.

## RTD Excitation Currents

The AD7711/AD7713 also contains two matched $200 \mu \mathrm{~A}$ constant current sources which are provided at the RTD1 and RTD2 pins of the device. These currents can be turned on/off via the control register. Writing a 1 to the RO bit of the control register enables these excitation currents.
For four-wire RTD applications, one of these excitation currents is used to provide the excitation current for the RTD, the second current source can be left unconnected. For three-wire RTD configurations, the second on-chip current source can be used to eliminate errors due to voltage drops across lead resistances.

The temperature coefficient of the RTD current sources is typically $20 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ with a typical matching between the temperature coefficients of both current sources of $3 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$. For applications where the absolute value of the temperature coefficient is too large, the following schemes can be used to remove the drift error.
The conversion result from the AD7711/AD7713 is ratiometric to the $\mathrm{V}_{\text {REF }}$ voltage. Therefore, if the $\mathrm{V}_{\text {REF }}$ voltage varies with the RTD temperature coefficient, the temperature drift from the current source will be removed. For four-wire RTD applications, the reference voltage can be made ratiometric to RTD current source by using the second current with a low TC resistor to generate the reference voltage for the part. In this case if a $12.5 \mathrm{k} \Omega$ resistor is used, the $200 \mu \mathrm{~A}$ current source generates +2.5 V across the resistor. This +2.5 V can be applied to the REF IN $(+)$ input of the part and with the REF IN $(-)$ input at ground it will supply a $\mathrm{V}_{\text {REF }}$ of 2.5 V for the part. For threewire RTD configurations, the reference voltage for the part is generated by placing a low TC resistor ( $12.5 \mathrm{k} \Omega$ for 2.5 V reference) in series with one of the constant current sources. The RTD current sources can be driven to within 2 V of $\mathrm{AV}_{\mathrm{DD}}$. The reference input of the part is differential so the REF IN(+) and REF IN $(-)$ of the part are driven from either side of the resistor. Both schemes ensure that the reference voltage for the part tracks the RTD current sources over temperature and, thereby, removes the temperature drift error.

## Bipolar/Unipolar Inputs

The AIN1 and AIN2 inputs on both parts can accept either unipolar or bipolar input voltage ranges while the AIN3 of the AD7713 accepts only unipolar signals. Bipolar or unipolar options for AIN1 and AIN2 are chosen by programming the B/U bit of the control register. This programs both channels for either unipolar or bipolar operation. Programming the part for either unipolar or bipolar operation does not change any of the input signal conditioning; it simply changes the data output coding. The data coding is binary for unipolar inputs and offset binary for bipolar inputs.

The AIN1 and AIN2 channels of the AD7713 and the AIN1 input of the AD7711 are differential, and as a result, the voltage to which the unipolar and bipolar signals are referenced is the voltage on the respective $\operatorname{AIN}(-)$ input. For example, if $\operatorname{AIN}(-)$ is +1.25 V and the part is configured for unipolar operation with a gain of 1 and a $\mathrm{V}_{\text {REF }}$ of +2.5 V , the input voltage range on the $\operatorname{AIN}(+)$ input is +1.25 V to +3.75 V . For theAIN3 input of the AD7713 and the AIN2 input of the AD7711, the input signals are referenced to AGND.

## REFERENCE INPUT

The reference inputs of the part, $\operatorname{REF} \operatorname{IN}(+)$ and $\operatorname{REF} \operatorname{IN}(-)$, provide a differential reference input capability. The commonmode range for these differential inputs is from $V_{S S}$ to $A V_{D D}$ (AGND to $\mathrm{AV}_{\mathrm{DD}}$ on AD7713). The nominal differential voltage, $\mathrm{V}_{\mathrm{REF}}(\operatorname{REF} \operatorname{IN}(+)-\operatorname{REF} \operatorname{IN}(-))$, is +2.5 V for specified operation but the reference voltage can go to +5 V with no degradation in performance provided that the absolute value of REF IN $(+)$ and REF IN $(-)$ does not exceed its supply limits. The part is also functional with $\mathrm{V}_{\text {REF }}$ voltages down to 1 V but with degraded performance as the output noise will, in terms of LSB size, be larger. REF IN(+) must always be greater than REF IN(-) for correct operation of the AD7711/AD7713.
Both reference inputs provide a high impedance, dynamic load similar to the analog inputs. The maximum dc input leakage current is $10 \mathrm{pA}( \pm 1 \mathrm{nA}$ over temperature $)$ and source resistance may result in gain errors on the part. The reference inputs look like the AIN1 analog input (see Figure 3). In this case, $\mathrm{R}_{\mathrm{INT}}$ is $5 \mathrm{k} \Omega$ typ and $\mathrm{C}_{\mathrm{INT}}$ varies with gain. The input sample rate is $\mathrm{f}_{\mathrm{CLK} \text { IN }} / 512$ and does not vary with gain. For gains of 1 to 8 $\mathrm{C}_{\text {INT }}$ is 20 pF ; for a gain of 16 it is 10 pF , for a gain of 32 it is 5 pF , for a gain of 64 it is 2.5 pF , and for a gain of 128 it is 1.25 pF .

The digital filter of the part removes noise from the reference input just as it does with the analog input, and the same limitations apply regarding lack of noise rejection at integer multiples of the sampling frequency. The output noise performance outlined in Tables I and II assumes a clean reference. If the reference noise in the bandwidth of interest is excessive, it can degrade the performance of the AD7711/AD7713. Recommended references for the AD7711/AD7713 are the AD680 and AD780, +2.5 V references.

## REFERENCE OUTPUT (AD7711 ONLY)

The AD7711 contains a temperature compensated +2.5 V reference which has an initial tolerance of $\pm 4 \%$. This reference voltage is provided at the REF OUT pin, and it can be used as the reference voltage for the part by connecting REF OUT to the REF IN(+) pin. This REF OUT pin is a single-ended output, referenced to AGND, which is capable of providing up to 1 mA to an external load. In applications where REF OUT is connected
directly to REF IN(+), REF IN(-) should be tied to AGND to provide the nominal +2.5 V reference for the AD7711.
Using the on-chip reference as the reference source for the part results in somewhat degraded output noise performance from the AD7711 for portions of the noise table that are dominated by the device noise. The on-chip reference noise effect is eliminated in ratiometric applications where the reference is used to provide the excitation voltage for the analog front end.

## $\mathbf{V}_{\text {biAS }}$ Input (AD7711 only)

The $\mathrm{V}_{\text {bias }}$ input determines at what voltage the internal analog circuitry is biased. It essentially provides the return path for analog currents flowing in the modulator and, as such, it should be driven from a low impedance point to minimize errors.
For maximum internal headroom, the $\mathrm{V}_{\text {BIAS }}$ voltage should be set halfway between $A V_{D D}$ and $V_{S S}$. The difference between $\mathrm{AV}_{\mathrm{DD}}$ and $\left(\mathrm{V}_{\text {BIAS }}+0.85 \times \mathrm{V}_{\mathrm{REF}}\right)$ determines the amount of headroom the circuit has at the upper end, while the difference between $\mathrm{V}_{\mathrm{SS}}$ and $\left(\mathrm{V}_{\text {BIAS }}-0.85 \times \mathrm{V}_{\text {REF }}\right)$ determines the amount of headroom the circuit has at the lower end. Care should be taken in choosing a $\mathrm{V}_{\text {bIAS }}$ voltage to ensure that it stays within prescribed limits. For single +5 V operation, the selected $\mathrm{V}_{\text {BIAS }}$ voltage must ensure that $\mathrm{V}_{\text {BIAS }} \pm 0.85 \times \mathrm{V}_{\text {REF }}$ does not exceed $A V_{D D}$ or $V_{S S}$ or that the $V_{\text {BIAS }}$ voltage itself is greater than $V_{S S}$ +2.1 V and less than $\mathrm{AV}_{\mathrm{DD}}-2.1 \mathrm{~V}$. For single +10 V operation or dual $\pm 5 \mathrm{~V}$ operation, the selected $\mathrm{V}_{\text {BIAs }}$ voltage must ensure that $\mathrm{V}_{\text {BIAS }} \times 0.85 \times \mathrm{V}_{\text {REF }}$ does not exceed $A V_{\mathrm{DD}}$ or $\mathrm{V}_{\text {SS }}$ or that the $V_{\text {BIAS }}$ voltage itself is greater than $V_{S S}+3 \mathrm{~V}$ or less than $\mathrm{AV}_{\mathrm{DD}}-3 \mathrm{~V}$. For example, with $\mathrm{AV}_{\mathrm{DD}}=+4.75 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}$ $=0 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{REF}}=+2.5 \mathrm{~V}$, the allowable range for the $\mathrm{V}_{\text {BIAS }}$ voltage is +2.125 V to +2.625 V . With $\mathrm{AV}_{\mathrm{DD}}=+9.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{Ss}}$ $=0 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{REF}}=5 \mathrm{~V}$, the range for $\mathrm{V}_{\text {BIAS }}$ is +4.25 V to +5.25 V . With $\mathrm{AV}_{\mathrm{DD}}=+4.75 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=-4.75 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{REF}}$ $=+2.5 \mathrm{~V}$, the $\mathrm{V}_{\text {BIAS }}$ range is -2.625 V to +2.625 V .
The $\mathrm{V}_{\text {BIAS }}$ voltage does have an effect on the $A V_{D D}$ power supply rejection performance of the AD7711. If the $\mathrm{V}_{\text {BIAS }}$ voltage tracks the $A V_{D D}$ supply, it improves the power supply rejection from the $A V_{D D}$ supply line from 80 dB to 95 dB . Using an external Zener diode, connected between the $A V_{\text {DD }}$ line and $\mathrm{V}_{\text {BIAS }}$, as the source for the $\mathrm{V}_{\text {BIAS }}$ voltage gives the improvement in $A V_{D D}$ power supply rejection performance.

## USING THE AD7711/AD7713 SYSTEM DESIGN CONSIDERATIONS

The AD7711/AD7713 operates differently from successive approximation ADCs or integrating ADCs. Since it samples the signal continuously, like a tracking ADC, there is no need for a start convert command. The output register is updated at a rate determined by the first notch of the filter and the output can be read at any time, either synchronously or asynchronously.

## Clocking

The AD7711/AD7713 requires a master clock input, which may be an external TTL/CMOS compatible clock signal applied to the MCLK IN pin with the MCLK OUT pin left unconnected. Alternatively, a crystal of the correct frequency can be connected between MCLK IN and MCLK OUT, in which case the clock circuit will function as a crystal controlled oscillator. For lower clock frequencies, a ceramic resonator may be used instead of the crystal. For these lower frequency oscillators, external capacitors may be required on either the ceramic resonator or on the crystal.

The input sampling frequency, the modulator sampling frequency, the -3 dB frequency, output update rate and calibration time are all directly related to the master clock frequency, $\mathrm{f}_{\mathrm{CLK} \text { in }}$. Reducing the master clock frequency by a factor of 2 will halve the above frequencies and update rate and will double the calibration time.

The current drawn from the $\mathrm{DV}_{\mathrm{DD}}$ power supply is also directly related to $f_{\text {CLK IN }}$. Reducing $f_{\text {CLK IN }}$ by a factor of 2 will halve the $\mathrm{DV}_{\mathrm{DD}}$ current but will not affect the current drawn from the $A V_{D D}$ power supply.

## System Synchronization

If multiple AD7711/AD7713s are operated from a common master clock, they can be synchronized to update their output registers simultaneously. A falling edge on the $\overline{\text { SYNC }}$ input resets the filter and places the part into a consistent, known state. A common signal to the parts' SYNC inputs will synchronize their operation. This would normally be done after each AD7711/ AD7713 has performed its own calibration or has had calibration coefficients loaded to it.
The $\overline{\text { SYNC }}$ input can also be used to reset the digital filter in systems where the turn-on time of the digital power supply ( $\mathrm{DV}_{\mathrm{DD}}$ ) is very long. In such cases, the AD7711/AD7713 will start operating internally before the $\mathrm{DV}_{\mathrm{DD}}$ line has reached its minimum operating level, +4.75 V . With a low $\mathrm{DV}_{\mathrm{DD}}$ voltage, the part's internal digital filter logic does not operate correctly. Thus, the AD7711/AD7713 may have clocked itself into an incorrect operating condition by the time that $D V_{D D}$ has reached its correct level. The digital filter will be reset upon issue of a calibration command (whether it is self-calibration, system calibration or background calibration) to the AD7711/ AD7713. This ensures correct operation of the AD7711/ AD7713. In systems where the power-on default conditions of the part are acceptable and no calibration is performed after power-on, issuing a $\overline{\text { SYNC }}$ pulse to the part will reset the AD7711/AD7713's digital filter logic. An R, C on the $\overline{\text { SYNC }}$ line, with $\mathrm{R}, \mathrm{C}$ time constant longer than the $\mathrm{DV}_{\mathrm{DD}}$ power-on time, will perform the SYNC function.

## ACCURACY

Sigma-Delta ADCs, like VFCs and other integrating ADCs, do not contain any source of nonmonotonicity and inherently offer no missing codes performance. The AD7711/AD7713 achieves excellent linearity by the use of high quality, on-chip silicon dioxide capacitors, which have a very low capacitance/voltage coefficient. The device also achieves low input drift through the use of chopper-stabilized techniques in its input stage. To ensure excellent performance over time and temperature, the AD7711/ AD7713 uses digital calibration techniques which minimize offset and gain error.

## AUTOCALIBRATION

Autocalibration on the AD7711/AD7713 removes offset and gain errors from the device. A calibration routine should be initiated on the device whenever there is a change in the ambient operating temperature or supply voltage. It should also be initiated if there is a change in the selected gain, filter notch or bipolar/ unipolar input range. However, if the AD7711/AD7713 is in its background calibration mode, the above changes are all automatically taken care of (after the settling time of the filter has been allowed for).

The AD7711/AD7713 offers self-calibration, system calibration and background calibration facilities. For calibration to occur on the selected channel, the on-chip microcontroller must record the modulator output for two different input conditions. These are "zero-scale" and "full-scale" points. With these readings, the microcontroller can calculate the gain slope for the input to output transfer function of the converter. Internally, the part works with a resolution of 33 bits to determine its conversion result of either 16 bits or 24 bits.
The part also provides the facility to write to the on-chip calibration registers and in this manner the span and offset for the part can be adjusted by the user. The offset calibration register contains a value which is subtracted from all conversion results, while the full-scale calibration register contains a value which is multiplied by all conversion results. The offset calibration coefficient is subtracted from the result prior to the multiplication by the full-scale coefficient. In the first three modes outlined here, the DRDY line indicates that calibration is complete by going low. If $\overline{\text { DRDY }}$ is low before (or goes low during) the calibration command, it may take up to one modulator cycle before $\overline{\mathrm{DRDY}}$ goes high to indicate that calibration is in progress. Therefore, $\overline{\mathrm{DRDY}}$ should be ignored for up to one modulator cycle after the last bit of the calibration command is written to the control register.

## Self-Calibration

In the self-calibration mode with a unipolar input range, the zero-scale point used in determining the calibration coefficients is with both inputs shorted (i.e., $\operatorname{AIN}(+)=\operatorname{AIN}(-)=\mathrm{V}_{\mathrm{BIAS}}$ for the differential inputs and AIN $=\mathrm{V}_{\text {BIAS }}$ for AIN2 of the AD7711 and AIN3 of the AD7713) and the full-scale point is $\mathrm{V}_{\mathrm{REF}}$. The zero-scale coefficient is determined by converting an internal shorted inputs node. The full-scale coefficient is determined from the span between this shorted inputs conversion and a conversion on an internal $\mathrm{V}_{\text {REF }}$ node. The self-calibration mode is invoked by writing the appropriate values $(0,0,1)$ to the MD2, MD1 and MD0 bits of the control register. In this calibration mode, the shorted inputs node is switched in to the modulator first and a conversion is performed; the $\mathrm{V}_{\text {REF }}$ node is then switched in and another conversion is performed. When the calibration sequence is complete, the calibration coefficients updated and the filter resettled to the analog input voltage, the $\overline{\text { DRDY }}$ output goes low. The self-calibration procedure takes into account the selected gain on the PGA.
For bipolar input ranges in the self-calibrating mode, the sequence is very similar to that just outlined. In this case, the two points which the AD7711/AD7713 calibrates are midscale (bipolar zero) and positive full scale.

## System Calibration

System calibration allows the AD7711/AD7713 to compensate for system gain and offset errors as well as its own internal errors. System calibration performs the same slope factor calculations as self-calibration but uses voltage values presented by the system to the AIN inputs for the zero and full-scale points. System calibration is a two-step process. The zero-scale point must be presented to the converter first. It must be applied to the converter before the calibration step is initiated and remain stable until the step is complete. System calibration is initiated by writing the appropriate values ( $0,1,0$ ) to the MD2, MD1 and MD0 bits of the control register. The $\overline{\text { DRDY }}$ output from the device will signal when the step is complete by going low. After the zero-scale point is calibrated, the full-scale point is applied and the second step of the calibration process is initiated
by again writing the appropriate values $(0,1,1)$ to MD2, MD1 and MD0. Again the full-scale voltage must be set up before the calibration is initiated and it must remain stable throughout the calibration step. $\overline{\text { DRDY }}$ goes low at the end of this second step to indicate that the system calibration is complete. In the unipolar mode, the system calibration is performed between the two endpoints of the transfer function; in the bipolar mode, it is performed between midscale and positive full scale.
This two-step system calibration mode offers another feature. After the sequence has been completed, additional offset or gain calibrations can be performed by themselves to adjust the zero reference point or the system gain. This is achieved by performing the first step of the system calibration sequence (by writing $0,1,0$ to MD2, MD1, MD0). This will adjust the zero scale or offset point but will not change the slope factor from what was set during a full system calibration sequence.
System calibration can also be used to remove any errors from an antialiasing filter on the analog input. A simple $\mathrm{R}, \mathrm{C}$ antialiasing filter on the front end may introduce a gain error on the analog input voltage but the system calibration can be used to remove this error.

## System Offset Calibration

System offset calibration is a variation of both the system calibration and self-calibration. In this case, the zero-scale point for the system is presented to the AIN input of the converter. System offset calibration is initiated by writing $1,0,0$ to MD2, MD1, MD0. The system zero-scale coefficient is determined by converting the voltage applied to the AIN input, while the fullscale coefficient is determined from the span between this AIN conversion and a conversion on $\mathrm{V}_{\mathrm{REF}}$. The zero-scale point should be applied to the AIN input for the duration of the calibration sequence. This is a one-step calibration sequence with $\overline{\text { DRDY }}$ going low when the sequence is completed. In the unipolar mode, the system offset calibration is performed between the two endpoints of the transfer function; in the bipolar mode, it is performed between midscale and positive full scale.

## Background Calibration

The AD7711/AD7713 also offers a background calibration mode where the part interleaves its calibration procedure with its normal conversion sequence. In the background calibration mode, the same voltages are used as the calibration points as are used in the self-calibration mode, i.e., shorted inputs and $\mathrm{V}_{\text {REF }}$. The background calibration mode is invoked by writing $1,0,1$ to MD2, MD1, MD0 of the control register. When invoked, the background calibration mode reduces the output data rate of the part by a factor of six while the -3 dB bandwidth remains unchanged. Its advantage is that the part is continually performing calibration and automatically updating its calibration coefficients. As a result, the effects of temperature drift, supply sensitivity and time drift on zero and full-scale errors are automatically removed. When the background calibration mode is turned on, the part will remain in this mode until bits MD2, MD1 and MD0 of the control register are changed. With background calibration mode on, the first result from the AD7711/ AD7713 will be incorrect as the full-scale calibration will not have been performed. For a step change on the input, the second output update will have settled to $100 \%$ of the final value.
Table IV summarizes the calibration modes and the calibration points associated with them. It also gives the duration from

## AD7711/AD7713

when the calibration is invoked to when valid data is available to the user

## Span and Offset Limits

Whenever a system calibration mode is used, there are limits on the amount of offset and span that can be accommodated. The range of input span in both the unipolar and bipolar modes for the AIN1 and AIN2 inputs of both the AD7711 and AD7713 has a minimum value of $0.8 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}$ and a maximum value of $2.1 \times \mathrm{V}_{\mathrm{REF}} /$ GAIN. For AIN3 of the AD7713, the minimum value is $3.2 \times \mathrm{V}_{\mathrm{REF}} /$ GAIN while the maximum value is $4.2 \times \mathrm{V}_{\mathrm{REF}} /$ GAIN.
The amount of offset that can be accommodated depends on whether the unipolar or bipolar mode is being used. This offset range is limited by the requirement that the positive full-scale calibration limit is $\leq 1.05 \times \mathrm{V}_{\mathrm{REF}} /$ GAIN for AIN1 and AIN2. Therefore, the offset range plus the span range cannot exceed
$1.05 \times \mathrm{V}_{\mathrm{REF}} /$ GAIN for AIN1 and AIN2. If the span is at its minimum ( $0.8 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}$ ) the maximum the offset can be is ( $0.25 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}$ ) for AIN1 and AIN2. For AIN3, both ranges are multiplied by a factor of 4 .

In the bipolar mode, the system offset calibration range is again restricted by the span range. The span range of the converter in bipolar mode is equidistant around the voltage used for the zero-scale point thus the offset range plus half the span range cannot exceed ( $1.05 \times \mathrm{V}_{\text {REF }} /$ GAIN) for AIN1 and AIN2. If the span is set to $2 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}$, the offset span cannot move more than $\pm\left(0.05 \times \mathrm{V}_{\mathrm{REF}} /\right.$ GAIN $)$ before the endpoints of the transfer function exceed the input overrange limits $\pm(1.05 \times$ $\mathrm{V}_{\mathrm{REF}} /$ GAIN) for AIN1. If the span range is set to the minimum $\pm\left(0.4 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}\right)$ the maximum allowable offset range is $\pm\left(0.65 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}\right)$ for AIN1 and AIN2. The AIN3 input can only be used in the unipolar mode.

Table IV. Calibration Truth Table

| Cal Type | MD2, MD1, MD0 | Zero-Scale Cal | Full-Scale Cal | Sequence | Duration |
| :--- | :--- | :--- | :--- | :--- | :--- |
| Self-Cal | $0,0,1$ | Shorted Inputs | V $_{\text {REF }}$ | One Step | $9 \times 1 /$ Output Rate |
| System Cal | $0,1,0$ |  | Two Step | $4 \times 1 /$ Output Rate |  |
| System Cal | $0,1,1$ | AIN | Two Step | $4 \times 1$ 1/Output Rate |  |
| System Offset Cal | $1,0,0$ | VIN | One Step | $9 \times 1 /$ Output Rate |  |
| Background Cal | $1,0,1$ | Shorted Inputs | $\mathrm{V}_{\text {REF }}$ | One Step | $6 \times 1 /$ Output Rate |

## POWER-UP AND CALIBRATION

On power-up, the AD7711/AD7713 performs an internal reset which sets the contents of the control register to a known state. However, to ensure correct calibration for the device, a calibration routine should be performed after power-up.

The power dissipation and temperature drift of the part are low and no warm-up time is required before the initial calibration is performed. However, the external reference must have stabilized before calibration is initiated.

## Drift Considerations

The AD7711/AD7713 uses chopper stabilization techniques to minimize input offset drift. Charge injection in the analog switches and dc:leakage currents at the sampling node are the primary sources of offset voltage drift in the converter. The dc input leakage current is essentially independent of the selected gain. Gain drift within the converter depends primarily upon the temperature tracking of the internal capacitors. It is not affected by leakage currents.

Measurement errors due to offset drift or gain drift can be eliminated at any time by recalibrating the converter or by operating the part in the background calibration mode. Using the system calibration mode can also minimize offset and gain errors in the signal conditioning circuitry. Integral and differential linearity errors are not significantly affected by temperature changes.

## POWER SUPPLIES AND GROUNDING

The analog and digital supplies to the AD7711/AD7713 are independent and separately pinned out to minimize coupling between the analog and digital sections of the device. The digital filter will provide rejection of broadband noise on the power supplies, except at integer multiples of the modulator sampling frequency. The digital supply ( $\mathrm{DV}_{\mathrm{DD}}$ ) must never exceed the analog positive supply ( $\mathrm{AV}_{\mathrm{DD}}$ ) by more than 0.3 V . Power supply sequencing is, therefore, important. If separate analog and
digital supplies are used, care must be taken to ensure that the analog supply is powered up first. If this cannot be ensured or if $\mathrm{DV}_{\mathrm{DD}}$ can exceed $\mathrm{AV}_{\text {DD }}$ at any other time, the protection scheme outlined in Figure 5 is recommended to protect the device. In systems where $A V_{D D}=+5 \mathrm{~V}$ and $\mathrm{DV}_{\mathrm{DD}}=+5 \mathrm{~V}$, it is recommended that $\mathrm{AV}_{\mathrm{DD}}$ and $\mathrm{DV}_{\mathrm{DD}}$ are driven from the same +5 V supply, although each supply should be decoupled separately. It is preferable that the common supply is the system's analog +5 V supply.

It is also important that power is applied to the AD7711/ AD7713 before signals at REF IN, AIN or the logic input pins in order to avoid latch-up. If separate supplies are used for the AD7711/AD7713 and the system digital circuitry, then the AD7711/AD7713 should be powered up first. If it is not possible to guarantee this, then current limiting resistors should be placed in series with the logic inputs.

*THIS DIODE MAY BE NECESSARY IF THE SHORT-CIRCUIT CURRENT FROM THE DIGITAL SUPPLY IS TOO LARGE FOR THE SD103C.

Figure 5. Protection Scheme for $D V_{D D}$ Powering-Up Before $A V_{D D}$

## DIGITAL INTERFACE

The digital interface section for the AD7711/AD7713 is identical to that outlined in the DIGITAL INTERFACE section of the AD7710/AD7712 data sheet.

LC²MOS Signal Conditioning ADC with RTD Current Source

## FEATURES

Charge Balancing ADC
24 Bits No Missing Codes $\pm 0.0015 \%$ Nonlinearity
Two-Channel Programmable Gain Front End Gains from 1 to 128
Differential Inputs
Low-Pass Filter with Programmable Filter Cutoffs
Ability to Read/Write Calibration Coefficients
Bidirectional Microcontroller Serial Interface
Internal/External Reference Option
Single or Dual Supply Operation
Low Power ( 25 mW typ) with Power-Down Mode ( 7 mW typ)

## APPLICATIONS <br> RTD Transducers

## GENERAL DESCRIPTION

The AD7711A is a complete analog front end for low frequency measurement applications. The device accepts low level signals directly from a transducer and outputs a serial digital word. It employs a sigma-delta conversion technique to realize up to 24 bits of no missing codes performance. The input signal is applied to a proprietary programmable gain front end based around an analog modulator. The modulator output is processed by an on-chip digital filter. The first notch of this digital filter can be programmed via the on-chip control register allowing adjustment of the filter cutoff and settling time.
The part features two differential analog inputs and a differential reference input. Normally, one of the channels will be used as the main channel with the second channel used as an auxiliary input to periodically measure a second voltage. It can be operated from a single supply (by tying the $\mathrm{V}_{\text {ss }}$ pin to AGND) provided that the input signals on the analog inputs are more positive than -30 mV . By taking the $\mathrm{V}_{\text {ss }}$ pin negative, the part can convert signals down to $-\mathrm{V}_{\text {REF }}$ on its inputs. The part also provides a $400 \mu \mathrm{~A}$ current source that can be used to provide excitation for RTD transducers. The AD7711A thus performs all signal conditioning and conversion for a single or dual channel system.

The AD7711A is ideal for use in smart, microcontroller based systems. Input channel selection, gain settings and signal polarity can be configured in software using the bidirectional serial port. The AD7711A contains self-calibration, system calibration and background calibration options and also allows the user to read and write the on-chip calibration registers.
*Protected by U.S. Patent No. 5,134,401.

$$
\left(A V_{D D}=+5 V \pm 5 \% ; D V_{D 0}=+5 V \pm 5 \% ; V_{S S}=0 V \text { or }-5 V \pm 5 \% ;\right.
$$

AD7711A-SPECIFICATIONS
REF IN( + ) $=+2.5 \mathrm{~V}$; REF IN( - ) = AGND; MCLK $\operatorname{IN}=10 \mathrm{MHz}$ unless otherwise stated. All specifications $\mathrm{T}_{\text {MII }}$ to $\mathrm{T}_{\text {max }}$, unless otherwise noted.)

| Parameter | A, S Versions ${ }^{1}$ | Units | Conditions/Comments - |
| :---: | :---: | :---: | :---: |
| STATIC PERFORMANCE |  |  |  |
| No Missing Codes | 24 | Bits min | Guaranteed by Design. For Filter Notches $\leq 60 \mathrm{~Hz}$ |
|  | 22 | Bits min | For Filter Notch $=100 \mathrm{~Hz}$ |
|  | 18 | Bits min | For Filter Notch $=250 \mathrm{~Hz}$ |
|  | 15 | Bits min | For Filter Notch $=500 \mathrm{~Hz}$ |
|  | 12 | Bits min | For Filter Notch $=1 \mathrm{kHz}$ |
| Output Noise | Tables I \& II |  | Depends on Filter Cutoffs and Selected Gain |
| Integral Nonlinearity |  |  |  |
| @ $25^{\circ} \mathrm{C}$ | $\pm 0.0045$ | \% of FSR max | Filter Notches $\leq 60 \mathrm{~Hz}$; Typically $\pm 0.0015 \%$ |
| $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ | $\pm 0.0075$ | \% of FSR max | Filter Notches $\leq 60 \mathrm{~Hz}$ |
| Positive Full-Scale Error ${ }^{2,3}$ | See Note 4 |  | Excluding Reference |
| Full-Scale Drift ${ }^{5}$ | 3/GAIN | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ | Excluding Reference. For Gains of 1, 2, 4, 8 |
|  | $0.35$ | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ | Excluding Reference. For Gains of 16, 32, 64, 128 |
| Unipolar Offset Error ${ }^{2}$ | See Note 4 |  |  |
| Unipolar Offset Drift ${ }^{5}$ | 2.5/GAIN | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ | For Gains of 1, 2, 4, 8 |
|  |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ | For Gains of 16, 32, 64, 128 |
| Bipolar Zero Error ${ }^{2}$ | See Note 4 |  |  |
| Bipolar Zero Drift ${ }^{5}$ | 2.5/GAIN | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ | For Gains of 1, 2, 4, 8 |
|  | 0.3 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ | For Gains of 16, 32, 64, 128 |
| Bipolar Negative Full-Scale Error ${ }^{2}$ | $\pm 0.006$ | \% of FSR max | Excluding Reference; Typically $\pm 0.0015 \%$ |
| Bipolar Negative Full-Scale Drift ${ }^{5}$ | $\begin{aligned} & \text { 4/GAIN } \\ & 0.5 \end{aligned}$ | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ | Excluding Reference. For Gains of 1, 2, 4, 8 <br> Excluding Reference. For Gains of 16, 32, 64, 128 |
| ANALOG INPUTS/REFERENCE INPUTS |  |  |  |
|  |  |  |  |
| Common-Mode Voltage Range ${ }^{6}$ | $\mathrm{V}_{\text {ss }}$ to $\mathrm{AV}_{\text {DD }}$ | $V$ min to $V$ max | - 13 |
| Normal Mode 50 Hz Rejection ${ }^{7}$ | 100 | dB min | For Filter Notches of $10,25,50 \mathrm{~Hz}, \pm 0.02 \times \mathrm{f}_{\text {NOTCH }}$ |
| Normal Mode 60 Hz Rejection ${ }^{7}$ | 100 | dB min | For Filter Notches of $10,30,60 \mathrm{~Hz}, \pm 0.02 \times \mathrm{f}_{\text {NOTCH }}$ |
| Common-Mode 50 Hz Rejection ${ }^{7}$ | 150 | dB min | For Filter Notches of $10,25,50 \mathrm{~Hz}, \pm 0.02 \times \mathrm{f}_{\text {NOTCH }}$ |
| Common-Mode 60 Hz Rejection ${ }^{7}$ | 150 | dB min | For Filter Notches of $10,30,60 \mathrm{~Hz}, \pm 0.02 \times \mathrm{f}_{\mathrm{NOTCH}}$ |
| DC Input Leakage Current ${ }^{7} @+25^{\circ} \mathrm{C}$ |  | PA max |  |
| $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ | 1 | $n A$ max |  |
| Sampling Capacitance ${ }^{7}$ | 20 | pF max |  |
| Analog Inputs ${ }^{8}$ |  |  |  |
| Input Sampling Rate, $\mathrm{f}_{\mathrm{s}}$ | $\begin{aligned} & 0 \text { to }+\mathrm{V}_{\mathrm{REF}}{ }^{10} \\ & \pm \mathrm{V}_{\mathrm{REF}} \\ & \text { See Table III } \end{aligned}$ | $\begin{array}{\|l\|l\|} \text { nom } \\ \text { nom } \end{array}$ | Unipolar Input Range (B/U Bit of Control Register = 1) Bipolar Input Range (B/U Bit of Control Register = 0) |
| $\begin{aligned} & \text { Reference Inputs } \\ & \text { REF IN }(+)-\text { REF IN }(-) \text { Voltage }{ }^{11} \\ & \text { Input Sampling Rate, } \mathrm{f}_{\mathrm{S}} \end{aligned}$ | $\begin{aligned} & +2.5 \text { to }+5 \\ & \mathrm{f}_{\text {CLK IN }} / 512 \end{aligned}$ | V min to V max | For Specified Performance. Part Functions with Lower V ReF Voltages |
| REFERENCE OUTPUT |  |  |  |
| Output Voltage | 2.5 | V nom |  |
| Initial Tolerance | $\pm 4$ | \% max |  |
| Drift | 20 | ppm/ ${ }^{\circ} \mathrm{C}$ typ |  |
| Output Noise | 50 | $\mu \mathrm{V}$ typ | pk-pk Noise 0.1 Hz to 10 Hz Bandwidth |
| Line Regulation ( $\mathrm{AV}_{\mathrm{DD}}$ ) | 1. | mV/V max |  |
| Load Regulation | 1.5 | $\mathrm{mV} / \mathrm{mA}$ max | Maximum Load Current 1 mA |
| External Current | 1 | mA max |  |

## NOTES

${ }^{1}$ Temperature ranges are as follows: A Version, $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; S Version $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. See also Note 16 ,
${ }^{2}$ Applies after calibration at the temperature of interest.
${ }^{3}$ Positive full-scale error applies to both unipolar and bipolar input ranges.
${ }^{4}$ These errors will be of the order of the output noise of the part as shown in Table I.
${ }^{5}$ Recalibration at any temperature or use of the background calibration mode will remove these drift errors.
${ }^{6}$ This common-mode voltage range is allowed provided that the input voltage on $\operatorname{AIN}(+)$ and $\operatorname{AIN}(-)$ does not exceed $\mathrm{AV}_{\mathrm{DD}}+30 \mathrm{mV}$ and $\mathrm{V}_{\mathrm{ss}}-30 \mathrm{mV}$.
${ }^{7}$ These numbers are guaranteed by design and/or characterization.
${ }^{8}$ The analog inputs present a very high impedance dynamic load which varies with clock frequency and input sample rate. The maximum recommended source resistance depends on the selected gain (see Tables IV and V).
${ }^{9}$ The analog input voltage range on the $\operatorname{AIN} 1(+)$ and $\operatorname{AIN} 2(+)$ inputs is given here with respect to the voltage on the AIN1(-) and AIN2(-) inputs. The absolute voltage on the analog inputs should not go more positive than $A V_{D D}+30 \mathrm{mV}$ or go more negative than $V_{s s}-30 \mathrm{mV}$.
${ }^{10} \mathbf{V}_{\text {REF }}=\operatorname{REF} \operatorname{IN}(+)-\operatorname{REF} \operatorname{IN}(-)$.
${ }^{11}$ The reference input voltage range may be restricted by the input voltage range requirement on the $\mathrm{V}_{\text {BIAs }}$ input.
This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

| Parameter | A, S Versions ${ }^{1}$ | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {BIAS }}$ INPUT $^{12}$ Input Voltage Range $\mathrm{V}_{\text {BIAS }}$ Rejection | $\begin{aligned} & \mathrm{AV}_{\mathrm{DD}}-0.85 \times \mathrm{V}_{\mathrm{REF}} \\ & \text { or } \mathrm{AV} \mathrm{~V}_{\mathrm{DD}}-3 \\ & \text { or } A V_{\mathrm{DD}}-2.1 \\ & \mathrm{~V}_{\mathrm{SS}}+0.85 \times \mathrm{V}_{\mathrm{REF}} \\ & \text { or } \mathrm{V}_{\mathrm{SS}}+3 \\ & \text { or } \mathrm{V}_{\mathrm{SS}}+2.1 \\ & 65 \text { to } 85 \end{aligned}$ | $V$ max <br> V max <br> V min <br> $V \min$ <br> dB typ | See $\mathrm{V}_{\text {Bias }}$ Input Section <br> Whichever Is Smaller; $+5 \mathrm{~V} /-5 \mathrm{~V}$ or $+10 \mathrm{~V} / 0 \mathrm{~V}$ <br> Nominal $\mathrm{AV}_{\mathrm{DD}} / \mathrm{V}_{\mathrm{SS}}$ <br> Whichever Is Smaller; $+5 \mathrm{~V} / 0 \mathrm{~V}$ Nominal $\mathrm{AV}_{\mathrm{DD}} / \mathrm{V}_{\mathrm{Ss}}$ <br> See V ${ }^{\text {bias }}$ Input Section <br> Whichever Is Greater; $+5 \mathrm{~V} /-5 \mathrm{~V}$ or $+10 \mathrm{~V} / 0 \mathrm{~V}$ <br> Nominal $\mathrm{AV}_{\mathrm{DD}} / \mathrm{V}_{\mathrm{SS}}$ <br> Whichever Is Greater; $+5 \mathrm{~V} / 0 \mathrm{~V}$ Nominal $\mathrm{AV}_{\mathrm{DD}} / \mathrm{V}_{\mathrm{SS}}$ Increasing with Gain |
| LOGIC INPUTS <br> Input Current <br> All Inputs Except MCLK IN <br> $\mathrm{V}_{\text {INL }}$, Input Low Voltage <br> $\mathrm{V}_{\text {INH }}$, Input High Voltage <br> MCLK IN Only <br> $\mathrm{V}_{\text {INL }}$, Input Low Voltage <br> $\mathrm{V}_{\text {INH }}$, Input High Voltage | $\begin{aligned} & \pm 10 \\ & 0.8 \\ & 2.0 \\ & 0.8 \\ & 3.5 \end{aligned}$ | $\mu \mathrm{A}$ max <br> V max <br> V min <br> V max <br> V min |  |
| LOGIC OUTPUTS <br> $\mathrm{V}_{\text {OL }}$, Output Low Voltage <br> $\mathrm{V}_{\mathrm{OH}}$, Output High Voltage <br> Floating State Leakage Current <br> Floating State Output Capacitance ${ }^{13}$ | $\begin{aligned} & 0.4 \\ & \mathrm{DV}_{\mathrm{DD}}-1 \\ & \pm 10 \\ & 9 \end{aligned}$ | $V \max$ <br> V min <br> $\mu \mathrm{A}$ max <br> pF typ | $\begin{aligned} & I_{\text {SINK }}=1.6 \mathrm{~mA} \\ & I_{\text {SOURCE }}=100 \mu \mathrm{~A} \end{aligned}$ |
| TRANSDUCER BURN-OUT <br> Current <br> Initial Tolerance <br> Drift | $\begin{aligned} & 100 \\ & \pm 10 \\ & 0.1 \end{aligned}$ | nA nom <br> $\%$ typ <br> $\%{ }^{\circ} \mathrm{C}$ typ |  |
| RTD EXCITATION CURRENT <br> Output Current <br> Initial Tolerance <br> Drift <br> Line Regulation ( $\mathrm{AV}_{\mathrm{DD}}$ ) <br> Load Regulation <br> Output Compliance | 0 400 $\pm 20$ 20 400 400 $A V_{D D}-2$ | $\mu \mathrm{A}$ nom $\mu A \max _{\text {max }}$ ppm $/{ }^{\circ} \mathrm{C}$ typ nA/V max $n A / V$ max V max | $A V_{D D}=+5 \mathrm{~V}$ |
| SYSTEM CALIBRATION <br> Positive Full-Scale Calibration Limit ${ }^{14}$ Negative Full-Scale Calibration Limit ${ }^{14}$ Offset Calibration Limit ${ }^{15}$ Input Span ${ }^{15}$ | $\begin{aligned} & \left(1.05 \times \mathrm{V}_{\mathrm{REF}}\right) / \mathrm{GAIN} \\ & -\left(1.05 \times \mathrm{V}_{\mathrm{REF}}\right) / \mathrm{GAIN} \\ & -\left(1.05 \times \mathrm{V}_{\mathrm{REF}}\right) / \mathrm{GAIN} \\ & 0.8 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN} \\ & \left(2.1 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}\right. \\ & \hline \end{aligned}$ | $V$ max <br> $V$ max <br> $V$ max <br> $V$ min <br> V max | GAIN Is the Selected PGA Gain (Between 1 and 128) GAIN Is the Selected PGA Gain (Between 1 and 128) GAIN Is the Selected PGA Gain (Between 1 and 128) GAIN Is the Selected PGA Gain (Between 1 and 128) GAIN Is the Selected PGA Gain (Between 1 and 128) |

## NOTES

${ }^{12}$ The AD7711A is tested with the following $\mathrm{V}_{\mathrm{BIAS}}$ voltages. With $\mathrm{AV} \mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{BIAS}}=+2.5 \mathrm{~V}$; with $\mathrm{AV} \mathrm{V}_{\mathrm{DD}}=+10 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}$, $\mathrm{V}_{\text {BIAS }}=+5 \mathrm{~V}$ and with $A \mathrm{~V}_{\mathrm{DD}}=+5 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{SS}}=-5 \mathrm{~V}, \mathrm{~V}_{\mathrm{BIAS}}=0 \mathrm{~V}$.
${ }^{13}$ Sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance.
${ }^{14}$ After calibration, if the analog input exceeds positive full scale, the converter will output all 1 s . If the analog input is less than negative full scale then the device will output all Os.
${ }^{15}$ These calibration and span limits apply provided the absolute voltage on the analog inputs does not exceed $\mathrm{AV}_{\mathrm{DD}}+30 \mathrm{mV}$ or go more negative than $\mathrm{V}_{\mathrm{ss}}-30 \mathrm{mV}$. The offset calibration limit applies to both the unipolar zero point and the bipolar zero point.

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## AD7711A-SPECIFICATIONS

| Parameter | A, S Versions ${ }^{1}$ | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: |
| POWER REQUIREMENTS |  |  |  |
| Power Supply Voltages |  |  | \% |
| $\mathrm{AV}_{\text {DD }}$ Voltage ${ }^{16}$ | +5 to +10 | V nom | $\pm 5 \%$ for Specified Performance |
| $\mathrm{DV}_{\text {DD }}$ Voltage $^{17}$ |  | V nom | $\pm 5 \%$ for Specified Performance |
| $\mathrm{AV}_{\text {DD }}-\mathrm{V}_{\text {ss }}$ Voltage | +10.5 | V max | For Specified Performance |
| Power Supply Currents |  |  |  |
| $\mathrm{AV}_{\text {DD }}$ Current | $4 \%$, | mA max |  |
| DV ${ }_{\text {DD }}$ Current | 4.5 | mA max |  |
| $\mathrm{V}_{\text {Ss }}$ Current | 1.5 | mA max | $\mathrm{V}_{\text {SS }}=-5 \mathrm{~V}$ |
| Power Supply Rejection ${ }^{18}$ |  | ? | Rejection w.r.t. AGND; Assumes $\mathrm{V}_{\text {bias }}$ Is Fixed |
| Positive Supply ( $\mathrm{AV}_{\mathrm{DD}}$ ) | See Note 19 | dB typ |  |
| Negative Supply ( $\mathrm{V}_{\text {SS }}$ ) | 90 | dB typ |  |
| Power Dissipation |  |  |  |
| Normal Mode | 45 | mW max | $\mathrm{AV}_{\mathrm{DD}}=\mathrm{DV}_{\mathrm{DD}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}$; Typically 25 mW |
| Normal Mode | 52.5 | mW max | $\mathrm{AV}_{\mathrm{DD}}=\mathrm{DV}^{\text {DD }}=+5 \mathrm{~V}, \mathrm{~V}_{S S}=-5 \mathrm{~V}$; Typically 30 mW |
| Standby (Power-Down) Mode | 15 | mW max | $\mathrm{AV}_{\mathrm{DD}}=\mathrm{DV}_{\mathrm{DD}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}$ or -5 V ; Typically 7 mW |

## NOTES

${ }^{16}$ The AD7711A is specified with a 10 MHz clock for $\mathrm{AV}_{\mathrm{DD}}$ voltages of $+5 \mathrm{~V} \pm 5 \%$. It is specified with an 8 MHz clock for $\mathrm{AV}_{\mathrm{DD}}$ voltages greater than 5.25 V and less than 10.5 V . Operation with $\mathrm{AV}_{\mathrm{DD}}$ voltages in the range 5.25 V to 10.5 V is only guaranteed over the 0 to $+70^{\circ} \mathrm{C}$ temperature range.
${ }^{17}$ The $\pm 5 \%$ tolerance on the $\mathrm{DV}_{\mathrm{DD}}$ input is allowed provided that $\mathrm{DV} \mathrm{DD}_{\mathrm{DD}}$ does not exceed $\mathrm{AV} \mathrm{DD}_{\mathrm{DD}}$ by more than 0.3 V .
${ }^{18}$ Measured at dc and applies in the selected passband. PSRR at 50 Hz will exceed 120 dB with filter notches of $10 \mathrm{~Hz}, 25 \mathrm{~Hz}$ or 50 Hz . PSRR at 60 Hz will exceed 120 dB with filter notches of $10 \mathrm{~Hz}, 30 \mathrm{~Hz}$ or 60 Hz .
${ }^{19}$ PSRR depends on gain: Gain of $1: 70 \mathrm{~dB}$ typ; Gain of $2: 75 \mathrm{~dB}$ typ; Gain of $4: 80 \mathrm{~dB}$ typ; Gains of 8 to $128: 85 \mathrm{~dB}$ typ. These numbers can be improved (to 95 dB typ) by deriving the $\mathrm{V}_{\text {BIAS }}$ voltage (via Zener diode or reference) from the $\mathrm{AV}_{\mathrm{DD}}$ supply.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS*

$\left(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right.$, unless otherwise noted).
$A V_{D D}$ to $\mathrm{DV}_{\mathrm{DD}} . . . . . . . . . . . . . . .-0.3$ Vto +12 V


$\mathrm{AV}_{\mathrm{DD}}$ to $\mathrm{DGND} . . . . . . . . . . . . . . . . .-0.3 \mathrm{~V}$ to +12 V
$\mathrm{DV}_{\mathrm{DD}}$ to AGND . . . . . . . . . . . . . . . . . . -0.3 V to +6 V
$\mathrm{DV}_{\mathrm{DD}}$ to DGND . . . . . . . . . . . . . . . . . . . -0.3 V to +6 V
$\mathrm{V}_{\text {ss }}$ to AGND . . . . . . . . . . . . . . . . . . . . . +0.3 V to -6 V
$\mathrm{V}_{\text {ss }}$ to DGND . . . . . . . . . . . . . . . . . . . . . +0.3 V to -6 V
Analog Input Voltage to AGND
................... $\mathrm{V}_{\mathrm{SS}}-0.3 \mathrm{~V}$ to $\mathrm{AV}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Reference Input Voltage to AGND
REF OUT to AGND . . . . . . . . . . . . . . . . . -0.3 V to $\mathrm{AV}_{\mathrm{DD}}+0.3 \mathrm{~V}$ to $\mathrm{AV}_{\mathrm{DD}}$

Digital Input Voltage to DGND . . . -0.3 V to $\mathrm{AV}_{\mathrm{DD}}+0.3 \mathrm{~V}$ Digital Output Voltage to DGND . . -0.3 V to $\mathrm{DV}_{\mathrm{DD}}+0.3 \mathrm{~V}$ Operating Temperature Range

Commercial (A Version) . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Extended (S Version) . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 secs) . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Power Dissipation (Any Package) to $+75^{\circ} \mathrm{C}$. . . . . . 450 mW
Derates Above $+75^{\circ} \mathrm{C}$. . . . . . . . . . . . . . . . . . . . . $6 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are inserted.


ORDERING GUIDE

| Model $^{\mathbf{1}}$ | Temperature <br> Range | Package <br> Option |
| :--- | :--- | :--- |
| AD7711AAN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-24$ |
| AD7711AAR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-24$ |

## NOTES

${ }^{1}$ To order MIL-STD-883B, Class B processed parts, add /883B to part number. Contact our local sales office for military data sheet and availability.
${ }^{2} \mathrm{~N}=$ Plastic DIP; R = SOIC. For outline information see Package Information section.

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## CONTROL REGISTER (24 BITS)

A write to the device with the A0 input low writes data to the control register. A read to the device with the A0 input low accesses the contents of the control register. The control register is 24 -bits wide and when writing to the register 24 bits of data must be written otherwise the data will not be loaded to the control register. In other words, it is not possible to write just the first 12 -bits of data into the control register. If more than 24 clock pulses are provided before TFS returns high, then all clock pulses after the 24th clock pulse are ignored. Similarly, a read operation from the control register should access 24 bits of data.

> MSB

| MD2 | MD1 | MD0 | G2 | G1 | G0 | CH | PD | WL | IO | BO | B/U |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| FS11* FS10 FS9 FS8 FS7 FS6 FS5 FS4 FS3 FS2 FS1 <br> FS0           |  |  |  |  |  |  |  |  |  |  |  |

${ }^{*}$ Must always be 0 to ensure correct operation of the device.

| Operating Mode |  |  | Operating Mode |
| :---: | :---: | :---: | :---: |
| MD2 | MD1 | MD0 |  |
| 0 | 0 | 0 | Normal Mode. This is the normal mode of operation of the device whereby a read to the device with A0 high accesses data from the data register. This is the default condition of these bits after the internal power on reset. |
| 0 | 0 | 1 | Activate Self-Calibration. This activates self-calibration on the channel selected by CH. This is a one-step calibration sequence, and when complete, the part returns to normal mode (with MD2, MD1, MD0 of the control register returning to $0,0,0$ ). The $\overline{\text { DRDY }}$ output indicates when this self-calibration is complete and valid data is available in the output register For this calibration type, the zero scale calibration is done internally on shorted (zeroed) inputs and the full-scale calibration is done internally on $\mathrm{V}_{\mathrm{REF}}$. |
| 0 | 1 | 0 | Activate System Calibration. This activates system calibration on the channel selected by CH. This is a two-step calibration sequence, with the zero scale calibration done first on the selected input channel and $\overline{\mathrm{DRDY}}$ indicating when this zero scale calibration is complete. The part returns to normal mode at the end of this first step in the two-step sequence. |
| 0 | 1 | 1 | Activate System Calibration. This is the second step of the system calibration sequence with full-scale calibration being performed on the selected input channel. Once again, $\overline{\mathrm{DRDY}}$ indicates when the full-scale calibration is complete. When this calibration is complete, the part returns to normal mode. |
| 1 | 0 | 0 | Activate System Offset Calibration. This activates system offset calibration on the channel selected by CH. This is a one-step calibration sequence and, when complete, the part returns to normal mode with DRDY indicating when this system offset calibration is complete. For this calibration type, the zero scale calibration is done on the selected input channel and the full-scale calibration is done internally on $\mathrm{V}_{\mathrm{REF}}$ - |
| 1 | 0 | 1 | Activate Background Calibration. This activates background calibration on the channel selected by CH. If the background calibration mode is on, then the AD7711A provides continuous self-calibration of the reference and shorted (zeroed) inputs. This calibration takes place as part of the conversion sequence, extending the conversion time and reducing the word rate by a factor of six. Its major advantage is that the user does not have to worry about recalibrating the device when there is a change in the ambient temperature. In this mode, the shorted (zeroed) inputs and $\mathrm{V}_{\text {REF }}$, as well as the analog input voltage, are continuously monitored and the calibration registers of the device are automatically updated. |
| 1 | 1 | 0 | Read/Write Zero Scale Calibration Coefficients. A read to the device with A0 high accesses the contents of the zero scale calibration coefficients of the channel selected by CH . A write to the device with A0 high writes data to the zero scale calibration coefficients of the channel selected by CH. The word length for reading and writing these coefficients is 24 bits, regardless of the status of the WL bit of the control register. Therefore, when writing to the calibration register 24 bits of data must be written, otherwise the new data will not be transferred to the calibration register. |
| 1 | 1 | 1 | Read/Write Full-Scale Calibration Coefficients. A read to the device with A0 high accesses the contents of the full-scale calibration coefficients of the channel selected by CH . A write to the device with A0 high writes data to the full-scale calibration coefficients of the channel selected by CH . The word length for reading and writing these coefficients is 24 bits, regardless of the status of the WL bit of the control register. Therefore, when writing to the calibration register 24 bits of data must be written, otherwise the new data will not be transferred to the calibration register. |

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Filter Selection (FS11-FS0)
The on-chip digital filter provides a Sinc ${ }^{3}\left(\operatorname{or}(\operatorname{Sin} x / x)^{3}\right)$ filter response. The 12 bits of data programmed into these bits determine the filter cutoff frequency, the position of the first notch of the filter and the data rate for the part. In association with the gain selection, it also determines the output noise (and hence the effective resolution) of the device.
The first notch of the filter occurs at a frequency determined by the relationship: filter first notch frequency $=\left(\mathrm{f}_{\mathrm{CLK}} \mathrm{IN} / 512\right) /$ code where code is the decimal equivalent of the code in bits FS0 to FS 11 and is in the range 19 to 2,000 . With the nominal $\mathrm{f}_{\mathrm{CLK}}$ in of 10 MHz , this results in a first notch frequency range from 9.76 Hz to 1.028 kHz . To ensure correct operation of the AD7711A, the value of the code loaded to these bits must be within this range. Failure to do this will result in unspecified operation of the device.

Changing the filter notch frequency, as well as the selected gain, impacts resolution. Tables I and II and Figure 2 show the effect of the filter notch frequency and gain on the effective resolution of the AD7711A. The output data rate (or effective conversion time) for the device is equal to the frequency selected for the first notch of the filter. For example, if the first notch of the filter is selected at 50 Hz , then a new word is available at a 50 Hz rate or every 20 ms . If the first notch is at 1 kHz , a new word is available every 1 ms .
The settling time of the filter to a full-scale step input change is worst case $4 \times 1$ (output data rate). This settling time is to $100 \%$ of the final value. For example, with the first filter notch at 50 Hz , the settling time of the filter to a full-scale step input change is 80 ms max. If the first notch is at 1 kHz , the settling time of the filter to a full-scale input step is 4 ms max. This settling time can be reduced to $3 \times 1$ /(output data rate) by synchronizing the step input change to a reset of the digital filter. In other words, if the step input takes place with $\overline{\text { SYNC }}$ low, the settling time will be $3 \times 1 /$ (output data rate). If a change of channels takes place, the settling time is $3 \times 1 /$ (output data rate) regardless of the $\overline{\text { SYNC }}$ input.

The -3 dB frequency is determined by the programmed first notch frequency according to the relationship: filter -3 dB frequency $=0.262 \times$ first notch frequency.
All other features and functions of the AD7711A are as per the AD7710. Refer to the AD7710/AD7712 data sheet for detailed description.

This information applies to a product under development. Its characteristics and specifications are subject to change without notice.
Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing. 3 V/5 V, CMOS, Low Cost, Low Power, Signal Conditioning ADC

FEATURES<br>Charge Balancing ADC 24 Bits No Missing Codes 0.0015\% Nonlinearity<br>Five-Channel Programmable Gain Front End Gains from 1 to 128<br>Can be Configured as Three Fully Differential Inputs or Five Pseudo-Differential Inputs Three-Wire Serial Interface<br>3 V (AD7714-3) or 5 V (AD7714-5) Operation<br>Low Power ( $750 \mu \mathbf{W}$ typ) with Power-Down ( $50 \mu \mathrm{~W}$ typ)<br>Low-Pass Filter with Programmable Filter Cutoffs Ability to Read/Write Calibration Coefficients<br>\section*{APPLICATIONS}<br>Portable Industrial Instruments<br>Portable Weigh Scales<br>Loop-Powered Systems<br>Smart Transmitters

## GENERAL DESCRIPTION

The AD7714 is a complete analog front end for low frequency measurement applications. The device accepts low level signals directly from a transducer and outputs a serial digital word It employs a sigma-delta conversion technique to realize up to 24 bits of no missing codes performance. The input signal is applied to a proprietary programmable gain front end based around an analog modulator. The modulator output is processed by an on-chip digital filter. The first notch of this digital filter can be programmed via the on-chip control register allowing adjustment of the filter cutoff and settling time.
The part features three differential analog inputs (which can also be configured as five pseudo-differential analog inputs) as well as a differential reference input. It operates from a single supply ( +3 V or +5 V ). The AD7714 thus performs all signal conditioning and conversion for a system consisting of up to five channels.
The AD7714 is ideal for use in smart, microcontroller- or DSPbased systems. It features a serial interface that can be configured for three-wire operation. Gain settings, signal polarity and channel selection can be configured in software using the input serial port. The AD7714 contains self-calibration, system calibration and background calibration options and also allows the user to read and write the on-chip calibration registers.
*Protected by U.S. Patent No. 5,134,401.

## FUNCTIONAL BLOCK DIAGRAM



CMOS construction ensures very low power dissipation, and the power-down mode reduces the standby power consumption to $50 \mu \mathrm{~W}$ typ. The part is available in a 24 -pin, 0.3 inch-wide, plastic and hermetic dual-in-line package (DIP); a 24 lead small outline (SOIC) package and a 28 -lead shrink small outline package (SSOP).

## PRODUCT HIGHLIGHTS

1. The AD7714 consumes less than $500 \mu \mathrm{~A}\left(\mathrm{f}_{\mathrm{CLK} \text { IN }}=1 \mathrm{MHz}\right)$ or $1 \mathrm{~mA}\left(\mathrm{f}_{\mathrm{CLK} \mathrm{IN}}=2.5 \mathrm{MHz}\right)$ in total supply current, making it ideal for use in loop-powered systems.
2. The programmable gain channels allow the AD7714 to accept input signals directly from a strain gage or transducer removing a considerable amount of signal conditioning.
3. The AD7714 is ideal for microcontroller or DSP processor applications with a three-wire serial interface reducing the number of interconnect lines and reducing the number of opto-couplers required in isolated systems. The part contains on-chip registers that allow control over filter cutoff, input gain, channel selection, signal polarity and calibration modes.
4. The part features excellent static performance specifications with 24 -bit no missing codes, $\pm 0.0015 \%$ accuracy and low rms noise ( $<300 \mathrm{mV}$ ). End-point errors and the effects of temperature drift are eliminated by on-chip self-calibration, which removes zero-scale and full-scale errors.
[^36]This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.


| Parameter | A, S Versions ${ }^{1}$ | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: |
| STATIC PERFORMANCE <br> No Missing Codes | $\begin{aligned} & 24 \\ & 22 \\ & 18 \\ & 15 \\ & 12 \end{aligned}$ |  |  |
|  |  | Bits min <br> Bits min Bits min Bits min Bits min |  |
|  |  |  | $\text { For Filter Notch }=100 \mathrm{~Hz}$ |
|  |  |  | For Filter Notch $=250 \mathrm{~Hz}$ |
|  |  |  | For Filter Notch $=500 \mathrm{~Hz}$ |
|  |  |  |  |
| Output Noise | See Tables I \& II |  | Depends on Filter Cutoffs and Selected Gain |
| Integral Nonlinearity | $\pm 0.0015$ | \% of FSR max | Filter Notches $\leq 60 \mathrm{~Hz}$ |
| Unipolar Offset Error ${ }^{2}$ | See Note 3 |  |  |
| Unipolar Offset Drift ${ }^{4}$ | 2.5/GAIN | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ | For Gains of $1,2,4,8$ <br> For Gains of $16,32,64,128$ |
| , | 0.3 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ |  |
| Bipolar Zero Error ${ }^{2}$ | See Note 3 |  |  |
| Bipolar Zero Drift ${ }^{4}$ | 2.5/GAIN | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ | For Gains of $1,2,4,8$ <br> For Gains of $16,32,64,128$ |
|  | 0.3 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ |  |
| Positive Full-Scale Error ${ }^{2}$ | See Note 3 |  |  |
| Full Scale Drift ${ }^{4,6}$ | 3/GAIN | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ | For Gains of 1, 2, 4, 8 |
|  | 0.35 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ |  |
| Gain Error ${ }^{2,7}$ | See Note 3 |  | For Gains of $16,32,64,128$ |
| Gain Drift ${ }^{4,8}$ | 2 | ppm of FSR $/{ }^{\circ} \mathrm{C}$ typ |  |
| Bipolar Negative Full-Scale Error ${ }^{2}$ | $\pm 0.0015$ | \% of FSR max | $\text { Typically } \pm 0.0004 \%$ |
| Bipolar Negative Full-Scale Drift ${ }^{4}$ | 4/GAIN 0.5 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ | For Gains of 1,2, 4, 8 <br> For Gains of 16, 32, 64, 128 |
| ANALOG INPUTS/REFERENCE INPUTS <br> Common-Mode Rejection (CMR) <br> Absolute/Common-Mode Range ${ }^{9}$ <br> Absolute/Common-Mode Range ${ }^{9}$ | $\cdots$ |  | Ât DC. See Table VI |
|  | 100 | dB min |  |
|  | AGND to $A V_{D D}$ | $V$ min to $V$ max |  |
|  | $\mathrm{AGND}+50 \mathrm{mV}$ to | V ${ }^{\text {a }}$ |  |
|  | $\mathrm{AV}_{\mathrm{DD}}-1.5 \mathrm{~V}$ | $V$ min to V | Analog Input with BUFFER $=1 \quad \therefore \quad \therefore$ |
| Normal-Mode 50 Hz Rejection ${ }^{10}$ | 100 | $\mathrm{Cb}^{\text {min }}$ | For Filter Notches of $10,25,50 \mathrm{~Hz}, \pm 0.02 \times \mathrm{f}_{\mathrm{NOTCH}}$ |
| Normal-Mode 60 Hz Rejection ${ }^{10}$ | 100 | dB min | For Filter Notches of $10,30,60 \mathrm{~Hz}, \pm 0.02 \times \mathrm{f}_{\text {NOTCH }}$ |
| Common-Mode 50 Hz Rejection ${ }^{10}$ | 150 | dB min | For Filter Notches of $10,25,50 \mathrm{~Hz}, \pm 0.02 \times \mathrm{f}_{\text {NOTCH }}$ |
| Common-Mode 60 Hz Rejection ${ }^{10}$ | 150 | dB min | For Filter Notches of $10,30,60 \mathrm{~Hz}, \pm 0.02 \times \mathrm{f}_{\text {NOTCH }}$ |
| Input Current ${ }^{10}$ | 1 | $n \mathrm{~A}$ max | BUFFER $=1$ |
| DC Input Leakage Current ${ }^{10}$ |  |  | BUFFER $=0$ |
| (a) $+25^{\circ} \mathrm{C}$ | 10 | pA max |  |
| $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ | 1 | $n A \max$ | O . . $\quad \therefore$ - .. |
| Sampling Capacitance ${ }^{10}$ | 10 | pF max |  |
| Analog Inputs ${ }^{11}$ |  |  |  |
| Input Voltage Range ${ }^{12}$ | $0 \text { to }+\mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}^{13}$ | nom | Unipolar Input Range (B/U Bit of Filter High Register = 1) |
|  | $\pm \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}$ | nom | Bipolar Input Range ( $\mathrm{B} / \mathrm{U}$ Bit of Filter High Register $=0$ ) |
| Input Sampling Rate, $\mathrm{f}_{\mathbf{S}}$ | GAIN $\times \mathrm{f}_{\text {CLK IN }} / 128$ $\mathrm{f}_{\text {CLK IN }} / 16$ |  | For Gains of $1,2,4$ For Gains of $8,16,32,64,128$ |
| Reference Inputs |  |  |  |
| REF IN(+) - REF IN(-) Voltage | +2.5 | $V$ nom | $\pm 5 \%$ for Specified Performance. Part Functions with <br> Lower $\mathrm{V}_{\mathrm{REF}}$ Voltages |
| Input Sampling Rate, $\mathrm{f}_{\mathrm{S}}$ | $\mathrm{f}_{\text {CLK IN }} / 128$ |  |  |
| LOGIC INPUTS |  |  |  |
| Input Current | $\pm 10$ | $\mu \mathrm{A}$ max |  |
| All Inputs except MCLK IN |  |  |  |
| $\mathrm{V}_{\text {INL }}$, Input Low Voltage | 0.8 | V max |  |
| $\mathrm{V}_{\text {INH }}$, Input High Voltage | 2.0 | V min | - . . |
| MCLK IN Only |  |  |  |
| $\mathrm{V}_{\text {INL }}$, Input Low Voltage | 0.8 | $V$ max | $D V_{\text {DD }}=+5 \mathrm{~V}$ |
| $\mathrm{V}_{\text {INL }}$, Input Low Voltage | 0.4 | $V$ max | $D V_{D D}=+3 \mathrm{~V}$ |
| $\mathrm{V}_{\text {INH }}$, Input High Voltage | 3.5 | V min | $D V_{\text {DD }}=+5 \mathrm{~V}$ |
| $\mathrm{V}_{\text {INH }}$, Input High Voltage | 2.5 | V min | $D V_{D D}=+3 \mathrm{~V}$ |
| LOGIC OUTPUTS |  |  |  |
| $\mathrm{V}_{\text {OL }}$, Output Low Voltage | 0.4 | V max | $\mathrm{I}_{\text {SINK }}=800 \mu \mathrm{~A}$. |
| $\mathrm{V}_{\mathrm{OH}}$, Output High Voltage | 4.0 | $V$ min | $\mathrm{I}_{\text {SOURCE }}=200 \mu \mathrm{~A} . \mathrm{DV}_{\mathrm{DD}}=+5 \mathrm{~V}$ |
| $\mathrm{V}_{\mathrm{OH}}$, Output High Voltage | DV $\mathrm{DD}^{-}-0.4$ | V min | $\mathrm{I}_{\text {SOURCE }}=200 \mu \mathrm{~A} . \mathrm{DV}_{\mathrm{DD}}=+3 \mathrm{~V}$ |
| Floating State Leakage Current | $\pm 10$ | $\mu \mathrm{A}$ max |  |
| Floating State Output Capacitance ${ }^{14}$ | 9 | pF typ |  |

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$\mathrm{f}_{\text {cixin }}=2.4576 \mathrm{MHz}$ unless otherwise stated. All specifications $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {mxx }}$ unless otherwise noted.)

| Parameter | A, S Versions ${ }^{1}$ | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: |
| STATIC PERFORMANCE No Missing Codes |  |  |  |
|  | 24 | Bits min | Guaranteed by Design. For Filter Notches $\leq 60 \mathrm{~Hz}$ |
|  | 22 | Bits min | For Filter Notch $=100 \mathrm{~Hz}$ |
|  | 18 | Bits $\min$ | For Filter Notch $=250 \mathrm{~Hz}$ |
|  | 15 | Bits min | For Filter Notch $=500 \mathrm{~Hz}$ |
|  | 12 | Bits min | For Filter Notch $=1 \mathrm{kHz}$ |
| Output Noise | See Tables III \& IV |  | Depends on Filter Cutoffs and Selected Gain |
| Integral Nonlinearity | $\pm 0.003$ | \% of FSR max | Filter Notches $\leq 60 \mathrm{~Hz}$ |
| Unipolar Offset Error ${ }^{2}$ | See Note 3 |  |  |
| Unipolar Offset Drifi ${ }^{4}$ | 2.5/GAIN | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ | For Gains of 1, 2, 4, 8 |
|  | 0.3 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ | For Gains of 16, 32, 64, 128 |
| Bipolar Zero Error ${ }^{2}$ | See Note 3 |  |  |
| Bipolar Zero Drifi ${ }^{4}$ | 2.5/GAIN | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ | For Gains of 1, 2, 4, 8 |
|  |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ | For Gains of 16, 32, 64, 128 |
| Positive Full-Scale Error ${ }^{2,5}$ | See Note 3 |  |  |
| Full-Scale Drifit ${ }^{4}$ | 3/GAIN | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ | For Gains of 1, 2, 4, 8 |
|  | 0.35 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ | For Gains of 16, 32, 64, 128 |
| Gain Error ${ }^{2} 7$ | See Note 3 |  |  |
| Gain Drift ${ }^{4,8}$ | 2 | ppm of FSR/ ${ }^{\circ} \mathrm{C}$ typ |  |
| Bipolar Negative Full-Scale Error ${ }^{2}$ | $\pm 0.003$ | \% of FSR max | Typically $\pm 0.0004 \%$ |
| Bipolar Negative Full-Scale Driff ${ }^{4}$ | 4/GAIN $0.5$ | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ | For Gains of $1,2,4,8$ <br> For Gains of 16, 32, 64, 128 |
| ANALOG INPUTS/REFERENCE INPUTS Common-Mode Rejection (CMR) Absolute Common-Mode Range ${ }^{6}$ Absolute Common-Mode Range ${ }^{6}$ |  |  |  |
|  | 94 | 1 mmin | AtDC. See Table VI |
|  | AGND to $\mathrm{AV}_{\text {DD }}$ ( | $\mathrm{V}_{\text {min }}$ to $\mathrm{V}_{\text {max }}$ |  |
|  | AGND +50 mbito |  |  |
|  | $\mathrm{AV}_{\mathrm{DD}}-1.5 \mathrm{X}$, | $V_{\text {min }}{ }^{\text {a }} \mathrm{V}^{\text {max }}$ | Analog Input with BUFFER $=1$ |
| Normal-Mode 50 Hz Rejection ${ }^{7}$ Normal-Mode 60 Hz Rejection ${ }^{7}$ | 100 ) | $\mathrm{dB}_{\min }$ | For Filter Notches of $10,25,50 \mathrm{~Hz}, \pm 0.02 \times \mathrm{f}_{\text {Notce }}$ |
|  |  | $\mathrm{dB}_{\mathrm{min}}{ }^{\text {d }}$, | For Filter Notches of $10,30,60 \mathrm{~Hz}, \pm 0.02 \times \mathrm{f}_{\text {notrem }}$ |
| Normmon-Mode 50 Hz Rejection ${ }^{7}$ |  | $\mathrm{dB}^{\text {min }}$ | For Filter Notches of 10, 25, $50 \mathrm{~Hz}, \pm 0.02 \times \mathrm{f}_{\text {Notch }}$ |
|  | 150 |  | For Filter Notches of $10,30,60 \mathrm{~Hz}, \pm 0.02 \times \mathrm{f}_{\text {Notch }}$ |
|  | 1 | $n A$ max | BUFFER $=1$ |
|  | 10 | pA max | BUFFER $=0$ |
| $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {Max }}$ | 1 | nA max |  |
| Sampling Capacitance ${ }^{7}$ | 10 | pF max |  |
| Analog Inputs ${ }^{\text {8 }}$ (nput Voltage Range ${ }^{\text {a }}$ |  |  |  |
|  | $\begin{aligned} & 0 \text { to }+\mathrm{V}_{\text {REFF }} / \mathrm{GAIIN}^{13} \\ & \pm \mathrm{V}_{\mathrm{RE} / \mathrm{GAIN}} \end{aligned}$ | nom | Unipolar Input Range (B/U Bit of Filter High Register = 1) Bipolar Input Range (B/U Bit of Filter High Register = 0) |
| Input Sampling Rate, ff | $\begin{aligned} & \text { GAIN } \times \mathrm{f}_{\text {CLKIN }} / 128 \\ & \mathrm{f}_{\text {CLK IN }} / 16 \end{aligned}$ |  | For Gains of $1,2,4$ <br> For Gains of $8,16,32,64,128$ |
| Reference Inputs |  |  |  |
| REF $\operatorname{IN}(+)-\operatorname{REF} \operatorname{IN}(-)$ Voltage |  | V nom | $\pm 5 \%$ for Specified Performance. Part Functions with Lower $\mathrm{V}_{\text {REF }}$ Voltages |
| Input Sampling Rate, $\mathrm{f}_{\mathrm{S}}$ | $\mathrm{f}_{\text {CLI IN/ }} / 28$ |  |  |
| LOGIC InPUTS |  |  |  |
| Input Current | $\pm 10$ | $\mu \mathrm{A}$ max |  |
| All Inputs except MCLK IN |  |  |  |
| $\mathrm{V}_{\text {INL }}$, Input Low Voltage | 0.8 | V max |  |
| $\mathrm{V}_{\text {INH }}$, Input High Voltage | 2.0 | V min |  |
| $\mathrm{V}_{\text {M }} \mathrm{MCLK}$ IN Input Low Voltage |  |  |  |
|  | 0.4 | V max |  |
| $\mathrm{V}_{\text {INH }}$, Input High Voltage | 2.5 | V min |  |
| LOGIC OUTPUTS |  |  |  |
| $\mathrm{V}_{\text {OL }}$ Output Low Voltage | 0.2 | V max | $\mathrm{I}_{\text {SINK }}=800 \mu \mathrm{~A}$ |
| $\mathrm{V}_{\mathrm{OH}}$, Output High Voltage | $\mathrm{DV}_{\mathrm{DD}}-0.4$ | V min | $\mathrm{I}_{\text {Source }}=200 \mu \mathrm{~A}$ |
| Floating State Leakage Current |  | $\mu \mathrm{A}$ max |  |
| Floating State Output Capacitance ${ }^{11}$ | 9 | pF typ |  |

## AD7714-SPECIFICATIONS

 2.4576 MHz unless otherwise stated. All specifications $\mathrm{T}_{\text {miN }}$ to $\mathrm{T}_{\text {max }}$ unless otherwise noted.)

| Parameter | A, $\mathbf{S}$ Versions | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: |
| SYSTEM CALIBRATION <br> Positive Full-Scale Calibration Limit ${ }^{15}$ Negative Full-Scale Calibration Limit ${ }^{15}$ Offset Calibration Limit ${ }^{16}$ Input Span ${ }^{16}$ |  |  |  |
|  | $\left(1.05 \times \mathrm{V}_{\text {REFF }} /\right.$ /GAIN | $V$ max | GAIN Is the Selected PGA Gain (Between 1 and 128) |
|  | $-\left(1.05 \times \mathrm{V}_{\text {REF }}\right) / \mathrm{GAIN}$ | $V$ max | GAIN Is the Selected PGA Gain (Between 1 and 128) |
|  | $-\left(1.05 \times \mathrm{V}_{\text {REF }}\right) / \mathrm{GAIN}$ | $V$ max | GAIN Is the Selected PGA Gain (Between 1 and 128) |
|  | $0.8 \times \mathrm{V}_{\text {REF }} / \mathrm{GAIN}$ | $V$ min | GAIN Is the Selected PGA Gain (Between 1 and 128) |
|  | $\left(2.1 \times \mathrm{V}_{\text {REF }}\right) /$ GAIN | $V$ max | GAIN Is the Selected PGA Gain (Between 1 and 128) |
| POWER REQUIREMENTS <br> Power Supply Voltages <br> $\mathrm{AV}_{\mathrm{DD}}$ Voltage (AD7714-3) <br> $\mathrm{AV}_{\mathrm{DD}}$ Voltage (AD7714-5) <br> $\mathrm{DV}_{\mathrm{DD}}$ Voltage |  |  |  |
|  |  |  |  |
|  | +2.7 to +3.6 | V nom | For Specified Performance |
|  | +5 | $V$ nom | $\pm 5 \%$ for Specified Performance |
|  | +2.7 to +5.25 | V nom | For Specified Performance |
| Power Supply Currents $\mathrm{AV}_{\mathrm{DD}}$ Current |  |  | $\mathrm{AV}_{\mathrm{DD}}=3 \mathrm{~V}$ or 5 V . BST Bit of Filter High Register $=0^{17}$ |
|  | 0.3 | mA max | Typically 0.2 mA . BUFFER $=0 \mathrm{~V}$. $\mathrm{f}_{\text {CLK }}$ IN $=1 \mathrm{MHz}$ or 2.4576 MHz |
|  | 0.6 | $m A$ max | Typically 0.4 mA. BUFFER $=+5 \mathrm{~V} . \mathrm{f}_{\text {CLK IN }}=1 \mathrm{MHz}$ or 2.4576 MHz $\mathrm{AV}_{\mathrm{DD}}=3 \mathrm{~V}$ or 5 V . BST Bit of Filter High Register $=1^{17}$ |
|  | 0.5 | mA max | Typically 0.3 mA . BUFFER $=0 \mathrm{~V} . \mathrm{f}_{\text {cLK }}$ IN $=2.4576 \mathrm{MHz}$ |
|  | 1 | $m A \max$ | Typically 0.8 mA . BUFFER $=+5 \mathrm{~V} . \mathrm{f}_{\text {CLK IN }}=2.4576 \mathrm{MHz}$ Digital I/Ps $=0 \mathrm{~V}$ or $\mathrm{DV}_{\mathrm{DD}}$ |
| DV ${ }_{\text {DD }}$ Current | 0.2 | mA max | Typically $0.15 \mathrm{~mA} . \mathrm{DV}_{\mathrm{DD}}=3 \mathrm{~V} . \mathrm{f}_{\text {CLK IN }}=1 \mathrm{MHz}$ |
|  | 0.4 | $m A$ max | Typically 0.3 mA DV $\mathrm{D}_{\mathrm{DD}}=5 \mathrm{~V} . \mathrm{f}_{\text {CLK }} \mathrm{IN}=1 \mathrm{MHz}$ |
|  | 0.5 | mA max | Typically $0.4 \mathrm{~mA} . \mathrm{DV}_{\mathrm{DD}}=3 \mathrm{~V} . \mathrm{f}_{\text {CLK }} \mathrm{IN}=2.4576 \mathrm{MHz}$ |
|  | 1 | mA max | Typically $0.8 \mathrm{~mA} . \mathrm{DV} \mathrm{VDD}=5 \mathrm{~V} . \mathrm{f}_{\text {CLK IN }}=2.4576 \mathrm{MHz}$ |
| Power Supply Rejection ${ }^{18}$ (AVDD) <br> Normal Mode Power Dissipation | See Note 19 | dB typ | $A V_{D D}=D V_{D D}=+3 \mathrm{~V} . \text { Digital } \mathrm{I} / \mathrm{Ps}_{\mathrm{S}}=0 \mathrm{~V} \text { or } \mathrm{DV}_{\mathrm{DD}} . \text { BST Bit }=0$ |
|  | 1.5 | mW max | Typically 1 mW . BUFFER $=0 \mathrm{~V} \cdot \mathrm{f}_{\text {CLK }} \mathrm{IN}=1 \mathrm{MHz}$ |
|  | 2.4 | mW max | Typically 1.6 mW. BUFFER $=+5 \mathrm{~V} . \mathrm{f}_{\text {CLK }} \mathrm{IN}=1 \mathrm{MHz}$ |
|  | 45 | mW max | Typically 2.1 mW. BUFFER $=0 \mathrm{~V} . \mathrm{f}_{\text {CLK }}$ IN $=2.4576 \mathrm{MHz}$ |
| Normal Mode Power Dissipation | 4.5 3.5 |  | Typically 3.6 mW . BUFFER $=+5 \mathrm{~V}$. $\mathrm{f}_{\text {CLK IN }}=2.4576 \mathrm{MHz}$ <br> $A \mathrm{~V}_{\mathrm{DD}}=\mathrm{DV}_{\mathrm{DD}}=+5 \mathrm{~V}$. Digital $\mathrm{I} / \mathrm{Ps}=0 \mathrm{~V}$ or $\mathrm{DV}_{\mathrm{DD}} . \mathrm{BST}$ Bit $=0$ |
|  | 3.5 5 | mW max mW max | Typically 2.5 mW . BUFFER $=0 \mathrm{~V} . \mathrm{f}_{\text {CLK IN }}=1 \mathrm{MHz}$ Typically 3.5 mW. BUFFER $=+5 \mathrm{~V} . \mathrm{f}_{\text {CLK IN }}=1 \mathrm{MHz}$ |
|  | 7.5 | mW max | Typically 5.5 mW. BUFFER $=0 \mathrm{~V} . \mathrm{f}_{\text {CLK IN }}=2.4576 \mathrm{MHz}$ |
|  | 10 | mW max | Typically 8 mW. BUFFER $=+5 \mathrm{~V} . \mathrm{f}_{\text {CLK IN }}=2.4576 \mathrm{MHz}$ |
| Standby (Power-Down) Dissipation | 100 | $\mu \mathrm{W}$ max | Typically $50 \mu \mathrm{~W}$ |

## NOTES

${ }^{1}$ Temperature ranges are as follows: A Version: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; S Version: $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
${ }^{2}$ Applies after calibration at the temperature of interest.
${ }^{3}$ These errors will be of the order of the output noise of the part as shown in Tables I to IV.
${ }^{4}$ Recalibration at any temperature will remove these drift errors.
${ }^{5}$ Positive Full-Scale Error includes Zero-Scale Errors (Unipolar Offset Error or Bipolar Zero Error) and applies to both unipolar and bipolar input ranges.
${ }^{6}$ Full-Scale Drift includes Zero-Scale Drift (Unipolar Offset Drift or Bipolar Zero Drift) and applies to both unipolar and bipolar input ranges.
${ }^{7}$ Gain Error does not include Zero-Scale Errors. It is calculated as Full-Scale Error-Unipolar Offset Error for unipolar ranges and Full-Scale Error-Bipolar Zero Error for bipolar ranges.
${ }^{8}$ Gain Drift does not include Unipolar Offset Drift/Bipolar Zero Drift. It is effectively the drift of the part if zero-scale calibrations only were performed as is the case with background calibration for gains of 64 and 128.
${ }^{9}$ This Common-Mode voltage range is allowed provided that the input voltage on the differential inputs does not go more positive than $A V_{\mathrm{DD}}+30 \mathrm{mV}$ or go more negative than AGND - 30 mV . The common-mode mode voltage applies to those inputs which form differential pairs (see Table VI).
${ }^{10}$ These numbers are guaranteed by design and/or characterization.
${ }^{11}$ The analog inputs present a very high impedance dynamic load which varies with clock frequency and input sample rate. The maximum recommended source resistance depends on the selected gain.
${ }^{12}$ The analog input voltage range on the analog inputs is given here with respect to the voltage on the respective negative input of its differential or pseudo-differential pair (see Table V ). The absolute voltage on the analog inputs should not go more positive than $\mathrm{AV}_{\mathrm{DD}}+30 \mathrm{mV}$ or go more negative than AGND - 30 mV .
${ }^{13} \mathrm{~V}_{\mathrm{REF}}=\operatorname{REF} \operatorname{IN}(+)-\operatorname{REF} \operatorname{IN}(-)$.
${ }^{14}$ Sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance.
${ }^{15}$ After calibration, if the analog input exceeds positive full scale, the converter will output all 1 s . If the analog input is less than negative full scale, then the device will output all 0 s .
${ }^{16}$ These calibration and span limits apply provided the absolute voltage on the analog inputs does not exceed $\mathrm{AV}_{\mathrm{DD}}+30 \mathrm{mV}$ or go more negative than AGND - 30 mV . The offset calibration limit applies to both the unipolar zero point and the bipolar zero point.
${ }^{17}$ For higher gains $(\geq 8)$ at $f_{\text {CLK IN }}=2.4576 \mathrm{MHz}$, the BST bit of the Filter High Register must be set to 1 . For other conditions, it can be set to 0 .
${ }^{18}$ Measured at dc and applies in the selected passband. PSRR at 50 Hz will exceed 120 dB with filter notches of $5,10,25$ or 50 Hz . PSRR at 60 Hz will exceed 120 dB with filter notches of $6,10,30$ or 60 Hz .
${ }^{19}$ PSRR depends on gain: Gain of 1: 70 dB typ; Gain of $2: 75 \mathrm{~dB}$ typ; Gain of $4: 80 \mathrm{~dB}$ typ; Gains of 8 to $128: 85 \mathrm{~dB}$ typ.
Specifications subject to change without notice.
This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.


| Parameter | Limit at $\mathrm{T}_{\text {MIN }}, \mathrm{T}_{\text {MAX }}$ (A, S Versions) | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: |
| $\mathrm{f}_{\text {CLKIN }}{ }^{3,4}$ | 400 | kHz min | Master Clock Frequency: Crystal Oscillator or Externally Supplied |
|  | 2.5 | MHz max | For Specified Performance |
| $\mathrm{t}_{\text {CLK INLO }}$ | $0.4 \times \mathrm{t}_{\text {CLK IN }}$ | ns min | Master Clock Input Low Time. $\mathrm{t}_{\text {CLK }}$ IN $=1 / \mathrm{f}_{\text {CLK }}$ IN |
| $\mathrm{t}_{\text {clik in }}$ | $0.4 \times \mathrm{t}_{\text {clk in }}$ | ns min | Master Clock Input High Time |
| $\mathrm{t}_{\mathrm{r}^{5}}$ | 50 | ns max | Digital Output Rise Time. Typically 20 ns |
| $\mathrm{t}_{\mathrm{f}}{ }^{5}$ | 50 | ns max | Digital Output Fall Time. Typically 20 ns |
| $\mathrm{t}_{\text {DRDY }}$ | $500 \times \mathrm{t}_{\text {clk in }}$ | ns nom | DRDY High Time |
| $\mathrm{t}_{1}$ | 1000 | ns min | SYNC Pulse Width |
| $\mathrm{t}_{2}$ | 1000 | ns min | RESET Pulse Width |
|  |  |  |  |
| $\mathrm{t}_{3}$ | 0 | ns min | $\overline{\mathrm{DRDY}}$ to $\overline{\mathrm{CS}}$ Setup Time |
| $\mathrm{t}_{4}$ | 20 | ns min | $\overline{\mathrm{CS}}$ Falling Edge to SCLK Falling Edge (POL $=1$ ) or SCLK Rising Edge ( $\mathrm{POL}=0$ ) Setup Time |
| $t_{5}{ }^{6}$ | 0 | ns min | SCLK Active Edge to Data Valid Delay ${ }^{7}$ |
|  | 20 | ns max | $\mathrm{DV}_{\mathrm{DD}}=+5 \mathrm{~V}$ - |
|  | 40 | ns max | $\mathrm{DV}_{\mathrm{DD}}=+3 \mathrm{~V}$, |
| $\mathrm{t}_{6}$ | 200 | ns min | SCLK High Pulse Width |
| $\mathrm{t}_{7}$ | 200 | ns min | - SCLK Low Pulse Width |
| $\mathrm{t}_{8}$ | 20 | ns min | $\overline{\text { CS }}$ Rising Edge to SCLK Rising Edge (POL = 1) or SCLK Falling Edge (POL = 0) Hold Time |
| $\mathrm{tg}_{9}{ }^{8}$ | 10 50 10 | ns min ns max | Bus Relinquish Time after SCLK Rising Edge (POL = 1) or SCLK Falling Edge (POL $=0$ ). $\mathrm{DV}_{\mathrm{DD}}=+5 \mathrm{~V}$ |
|  | 100 | ns max | - SCLK Falling Edge (POL $=0$ ). $\mathrm{DV}_{\mathrm{DD}}=+3 \mathrm{~V}$ |
| $\mathrm{t}_{10}$ | 50 | ns max | SCLK Rising Edge ( $\mathrm{POL}=1$ ) or SCLK Falling Edge (POL $=0$ ) to DRDY $\mathrm{High}^{9}$ |
| Write Operation 20 , |  |  |  |
| $\mathrm{t}_{11}$ | 20 | ns min | $\overline{\mathrm{CS}}$ Falling Edge to SCLK Falling Edge (POL = 1) or SCLK Rising Edge (POL = 0) Setup Time |
| $\mathrm{t}_{12}$ | 30 | ns min | Data Valid to SCLK Active Edge Setup Time ${ }^{6}$ |
| $\mathrm{t}_{1}$ | 20 | ns min | Data Valid to SCLK Active Edge Hold Time ${ }^{6}$ |
| $\mathrm{t}_{14}$ | 200 | ns min | SCLK High Pulse Width |
| $\mathrm{t}_{15}$ | 200 | ns min | SCLK Low Pulse Width |
| $\mathrm{t}_{16}$ | 20 | ns min | CS Rising Edge to SCLK Rising Edge (POL = 1) or SCLK Falling Edge (POL = 0) Hold Time |

## NOTES

${ }^{1}$ Sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance. All input signals are specified with $\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}\left(10 \%\right.$ to $90 \%$ of $\left.\mathrm{DV} \mathrm{DD}_{\mathrm{DD}}\right)$ and timed from a voltage level of 1.6 V .
${ }^{2}$ See Figures 2 and 3.
${ }^{3}$ CLKIN Duty Cycle range is $45 \%$ to $55 \%$. CLKIN must be supplied whenever the AD7714 is not in standby mode. If no clock is present in this case, the device can draw higher current than specified and possibly become uncalibrated.
${ }^{4}$ The AD7714 is production tested with $\mathrm{f}_{\text {CLLKIN }}$ at $2.5 \mathrm{MHz}\left(1 \mathrm{MHz}\right.$ for some $\mathrm{I}_{\mathrm{DD}}$ tests). It is guaranteed by characterization to operate at 400 kHz .
${ }^{5}$ Specified using $10 \%$ and $90 \%$ points on waveform of interest.
${ }^{6}$ These numbers are measured with the load circuit of Figure 1 and defined as the time required for the output to cross the $V_{\mathrm{OL}}$ or $\mathrm{V}_{\mathrm{OH}}$ limits.
${ }^{7}$ SCLK active edge is falling edge of SCLK with POL $=1 ;$ SCLK active edge is rising edge of SCLK with POL $=0$.
${ }^{8}$ These numbers are derived from the measured time taken by the data output to change 0.5 V when loaded with the circuit of Figure 1 . The measured number is then extrapolated back to remove effects of charging or discharging the 100 pF capacitor. This means that the times quoted in the timing characteristics are the true bus relinquish times of the part and as such are independent of external bus loading capacitances.
${ }^{9} \overline{\mathrm{DRDY}}$ returns high after the first read from the device after an output update. The same data can be read again, if required, while $\overline{\mathrm{DRDY}}$ is high although care should be taken that subsequent reads do not occur close to the next output update.

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Figure 1. Load Circuit for Access Time and Bus Relinquish Time

ORDERING GUIDE

| Model | AV <br> Supply | Temperature <br> Range | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD7714AN-5 | 5 V | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-24$ |
| AD7714AR-5 | 5 V | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-24$ |
| AD7714ARS-5 | 5 V | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{RS}-28$ |
| AD7714SQ-5 | 5 V | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-24$ |
| AD7714AN-3 | 3 V | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-24$ |
| AD7714AR-3 | 3 V | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-24$ |
| AD7714ARS-3 | 3 V | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{RS}-28$ |
| AD7714SQ | $3 \mathrm{~V} \mathrm{\& 5} \mathrm{~V}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-24$ |

${ }^{\star} \mathrm{N}=$ Plastic DIP; R = SOIC; RS = SSOP; $\mathrm{Q}=$ Cerdip. For outline information see Package Information section.

ABSOLUTE MAXIMUM RATINGS*
( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)
AV ${ }_{\text {DD }}$ to AGND . . . . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to +7 V


DV ${ }_{\text {DD }}$ to DGND . . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to +7 V
Analog Input Voltage to AGND . . . . . -0.3 V to $\mathrm{AV}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Reference Input Voltage to AGND . . . -0.3 V to $\mathrm{AV}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Digital Input Voltage to DGND . . . . -0.3 V to $\mathrm{DV}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Digital Output Voltage to DGND . . . -0.3 V to $\mathrm{DV}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Operating Temperature Range
Commercial (A Version) . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Extended (S Version) . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Junction Temperature . . . . . . . . . . . . . . . . . . . . . . . . . $+150^{\circ} \mathrm{C}$
Plastic DIP Package, Power Dissipation . . . . . . . . . . . 450 mW
$\theta_{\mathrm{JA}}$ Thermal Impedance . . . . . . . . . . . . . . . . . . . . . $105^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature (Soldering, 10 sec ) . . . . . . . . . . $+260^{\circ} \mathrm{C}$
Cerdip Package, Power Dissipation . . . . . . . . . . . . . . . 450 mW
$\theta_{\mathrm{JA}}$ Thermal Impedance . . . . . . . . . . . . . . . . . . . . . . $70^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature (Soldering, 10 sec ) . . . . . . . . . . $+300^{\circ} \mathrm{C}$
SOIC Package, Power Dissipation . . . . . . . . . . . . . . . . 450 mW
$\theta_{\mathrm{JA}}$ Thermal Impedance . . . . . . . . . . . . . . . . . . . . . . $75^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature, Soldering
Vapor Phase ( 60 sec ) . . . . . . . . . . . . . . . . . . . . . . $+215^{\circ} \mathrm{C}$
Infrared ( 15 sec ) . . . . . . . . . . . . . . . . . . . . . $+220^{\circ} \mathrm{C}$
Power Dissipation (Any Package) to $+75^{\circ} \mathrm{C}$. . . . . . . . 450 mW
*Stresses above those listed under "Absolute Maximum Ratings" may cause
permanent damage to the device. This is a stress rating only, and functional
operation of the device at these or any other conditions above those listed in the
operational sections of this specification is not implied. Exposure to absolute
maximum rating conditions for extended periods may affect device reliability.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD7714 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


PIN CONFIGURATIONS


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## PIN FUNCTION DESCRIPTION

## DIP/SOIC PIN NUMBERS

| Pin <br> No. | Mnemonic | Function |
| :---: | :---: | :---: |
| 1 | SCLK | Serial Clock. Logic Input. An external serial clock is applied to this input to access serial data from the AD7714. This serial clock can be a continuous clock with all data transmitted in a continuous train of pulses. Alternatively, it can be a noncontinuous clock with the information being transmitted to the AD7714 in smaller batches of data. |
| 2 | MCLK IN | Master Clock signal for the device. This can be provided in the form of a crystal or external clock. A crystal can be tied across the MCLK IN and MCLK OUT pins. Alternatively, the MCLK IN pin can be driven with a CMOS-compatible clock and MCLK OUT left unconnected. The clock input frequency is nominally either 2.5 MHz or 1 MHz . |
| 3 | MCLK OUT | When the master clock for the device is a crystal, the crystal is connected between MCLK IN and MCLK OUT. |
| 4 | POL | Clock Polarity. Logic Input. With this input low, the first transition of the serial clock in a data transfer operation is from a low to a high. In microcontroller applications this means that the serial clock should idle low between data transfers. With this input high, the first transition of the serial clock in a data transfer operation is from a high to a low. In microcontroller applications, this means that the serial clock should idle high between data transfers. |
| 5 | $\overline{\text { SYNC }}$ | Logic Input which allows for synchronization of the digital filters and analog modulators when using a number of AD7714s. While SYNC is low, the nodes of the digital filter, the filter control logic and the calibration control logic are reset and the analog modulator is also held in its reset state. |
| 6 | $\overline{\text { RESET }}$ | Logic Input. Active low input which resets the control logic, interface logic, digital filter and analog modulator of the part to power-on status. |
| 7 | AIN1 | Analog Input Channel 1. Programmable-gain analog input which can be used as a pseudo-differential input when used with AIN6 or as the positive input of a differential analog input pair when used with AIN2 (see Communications Register section). |
| 8 | AIN2 | Analog Input Channel 2. Programmable-gain analog input which can be used as a pseudo-differential input when used with AIN6 or as the negative input of a differential analog input pair when used with AIN1 (see Communications Register section). |
| 9 | AIN3 | Analog Input Channel 3. Programmable-gain analog input which can be used as a pseudo-differential input when used with AIN6 or as the positive input of a differential analog input pair when used with AIN4 (see Communications Register section). |
| 10 | AIN4 | Analog Input Channel 4. Programmable-gain analog input which can be used as a pseudo-differential input when used with AIN6 or as the negative input of a differential analog input pair when used with AIN3 (see Communications Register section). |
| 11 | STANDBY | Logic Input. Taking this pin low shuts down the analog and digital circuitry, reducing power consumption to typically $50 \mu \mathrm{~W}$. |
| 12 | $\mathrm{AV}_{\mathrm{DD}}$ | Analog Positive Supply Voltage, +3 V nominal (AD7714-3) or +5 V nominal (AD7714-5). |
| 13 | BUFFER | Buffer Option Select. Logic Input. With this input low, the on-chip buffer on the analog input (after the multiplexer and before the analog modulator) is shorted out. With the buffer shorted out the current flowing in the $\mathrm{AV}_{\mathrm{DD}}$ line is reduced to $300 \mu \mathrm{~A}\left(\mathrm{f}_{\mathrm{CLK} \text { IN }}=1 \mathrm{MHz}\right.$ ) or $500 \mu \mathrm{~A}$ ( $\mathrm{f}_{\mathrm{CLK} \mathrm{IN}}=2.5 \mathrm{MHz}$ ). With this input high, the on-chip buffer is in series with the analog input allowing the inputs to handle higher source impedances. |
| 14 | REF IN(-) | Reference Input. Negative input of the differential reference input to the AD7714. The REF IN $(-)$ can lie anywhere between $\mathrm{AV}_{\mathrm{DD}}$ and AGND provided $\operatorname{REF} \operatorname{IN}(+)$ is greater than REF IN(-). |
| 15 | REF IN(+) | Reference Input. Positive input of the differential reference input to the AD7714. The reference input is differential with the provision that REF $\operatorname{IN}(+)$ must be greater than REF $\operatorname{IN}(-)$. REF $\operatorname{IN}(+)$ can lie anywhere between $\mathrm{AV}_{\mathrm{DD}}$ and AGND. |
| 16 | AIN5 | Analog Input Channel 5. Programmable-gain analog input which is the positive input of a differential analog input pair when used with AIN6 (see Communications Register section). |
| 17 | AIN6 | Analog Input Channel 6. Reference point for AIN1 through AIN4 in pseudo-differential mode or as the negative input of a differential analog input pair when used with AIN5 (see Communications Register section). |
| 18 | AGND | Ground reference point for analog circuitry. |


| $\begin{aligned} & \text { Pin } \\ & \text { No. } \end{aligned}$ | Mnemonic | Function |
| :---: | :---: | :---: |
| 19 | $\overline{\mathrm{CS}}$ | Chip Select. Active low Logic Input used to select the AD7714. With this input hard-wired low, the AD7714 can operate in its three-wire interface mode with SCLK, DIN and DOUT used to interface to the device. $\overline{\mathrm{CS}}$ can be used to select the device in systems with more than one device on the serial bus or as a frame synchronization signal in communicating with the AD7714. |
| 20 | $\overline{\text { DRDY }}$ | Logic output. A logic low on this output indicates that a new output word is available from the AD7714 data register. The $\overline{\mathrm{DRDY}}$ pin will return high upon completion of a read operation of a full output word. If no data read has taken place, after an output update, the $\overline{\mathrm{DRDY}}$ line will return high for $500 \times \mathrm{t}_{\mathrm{CLK}}$ IN cycles prior to he next output update. This gives an indication of when a read operation should not be attempted to avoid reading from the data register as it is being updated. $\overline{\mathrm{DRDY}}$ is also used to indicate when the AD7714 has completed its on-chip calibration sequence. |
| 21 | DOUT | Serial Data Output with serial data being read from the output shift register on the part. This output shift register can contain information from the calibration registers, mode register, communications register, filter selection registers or data register depending on the register selection bits of the Communications Register. |
| 22 | DIN | Serial Data Input with serial data being written to the input shift register on the part. Data from this input shift register is transferred to the calibration registers, mode register, communications register or filter selection registers depending on the register selection bits of the Communications Register. |
| 23 | DV ${ }_{\text {DD }}$ | Digital Supply Voltage, +3 V or +5 V nominal. |
| 24 | DGND | Ground reference point for digital circuitry. |

## TERMINOLOGY*

## INTEGRAL NONLINEARITY

This is the maximum deviation of any code from a straight line passing through the endpoints of the transfer function. The endpoints of the transfer function are zero-scale (not to be confused with bipolar zero), a point 0.5 LSB below the first code transition ( $000 \ldots 000$ to $000 \ldots 001$ ) and Full-Scale, a point 0.5 LSB above the last code transition ( $111 \ldots 110$ to $111 \ldots 111$ ). The error is expressed as a percentage of full scale.

## POSITIVE FULL-SCALE ERROR

Positive Full-Scale Error is the deviation of the last code transition (111 ... 110 to $111 \ldots 111$ ) from the ideal $\operatorname{AIN}(+)$ voltage (AIN(-) $+\mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}-3 / 2 \mathrm{LSB}$ ). It applies to both unipolar and bipolar analog input ranges.

## UNIPOLAR OFFSET ERROR

Unipolar Offset Error is the deviation of the first code transition from the ideal $\operatorname{AIN}(+)$ voltage (AIN(-) + 0.5 LSB) when operating in the unipolar mode.

## BIPOLAR ZERO ERROR

This is the deviation of the midscale transition ( 0111 . . . 111 to $1000 \ldots 000$ ) from the ideal $\operatorname{AIN}(+)$ voltage (AIN(-) 0.5 LSB ) when operating in the bipolar mode.

## GAIN ERROR

This is a measure of the span error of the ADC. It includes fullscale errors but not zero-scale errors. For unipolar input ranges it is defined as (full-scale error-unipolar offset error) while for bipolar input ranges it is defined as (full-scale error-bipolar zero error).

## BIPOLAR NEGATIVE FULL-SCALE ERROR

This is the deviation of the first code transition from the ideal $\operatorname{AIN}(+)$ voltage (AIN(-) - $\mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}+0.5 \mathrm{LSB}$ ), when operating in the bipolar mode.

## POSITIVE FULL-SCALE OVERRANGE

Positive Full-Scale Overrange is the amount of overhead available to handle input voltages on $\operatorname{AIN}(+)$ input greater than AIN $(-)+V_{\text {ReF }} / G A I N$ (for example, noise peaks or excess voltages due to system gain errors in system calibration routines) without introducing errors due to overloading the analog modulator or overflowing the digital filter.

## NEGATIVE FULL-SCALE OVERRANGE

This is the amount of overhead available to handle voltages on AIN(+) below AIN(-) - V VEF $/$ GAIN without overloading the analog modulator or overflowing the digital filter. Note that the analog input will accept negative voltage peaks even in the unipolar mode provided that $\operatorname{AIN}(+)$ is greater than $\operatorname{AIN}(-)$ and greater than AGND - 30 mV .

## OFFSET CALIBRATION RANGE

In the system calibration modes, the AD7714 calibrates its offset with respect to the analog input. The Offset Calibration Range specification defines the range of voltages that the AD7714 can accept and still calibrate offset accurately.

## FULL-SCALE CALIBRATION RANGE

This is the range of voltages that the AD7714 can accept in the system calibration mode and still calibrate full-scale correctly.

## INPUT SPAN

In system calibration schemes, two voltages applied in sequence to the AD7714's analog input define the analog input range. The input span specification defines the minimum and maximum input voltages from zero to full-scale that the AD7714 can accept and still calibrate gain accurately.

[^37][^38]AD7714-5 Output Noise
Table I shows the output rms noise and effective resolution for some typical notch and -3 dB frequencies for the AD7714-5 with $\mathrm{f}_{\mathrm{CLK} \mathrm{IN}}=2.4576 \mathrm{MHz}$ while Table II gives the information for $\mathrm{f}_{\mathrm{CLK} \mathrm{IN}}=1 \mathrm{MHz}$. The numbers given are for the bipolar input ranges with a $\mathrm{V}_{\mathrm{REF}}$ of +2.5 V and with $\mathrm{BUFFER}=0$. These numbers are typical and are generated at an analog input voltage of 0 V . The numbers in brackets in each table are for the effective resolution of the part (rounded to the nearest 0.5 LSB ). The effective resolution of the device is defined as the ratio of the output rms noise to the input full-scale (i.e., $2 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}$ ). It should be noted that it is not calculated using peak-to-peak output noise numbers. Peak-to-peak noise numbers can be up to 6.6 times the rms numbers while effective resolution numbers based on peak-to-peak noise can be 2.5 bits below the effective resolution based on rms noise as quoted in the tables.
The output noise from the part comes from two sources. The first is the electrical noise in the semiconductor devices used in the implementation of the modulator (device noise). Secondly, when the analog input signal is converted into the digital domain, quantization noise is added. The device noise is at a low level and is largely independent of frequency. The quantization noise starts at an even lower level but rises rapidly with increasing frequency to become the dominant noise source. Consequently, lower filter notch settings (below 100 Hz approximately for $\mathrm{f}_{\text {CLK IN }}=2.4576 \mathrm{MHz}$ and below 40 Hz approximately for $\mathrm{f}_{\text {CLK IN }}=1 \mathrm{MHz}$ ) tend to be device noise dominated while higher notch settings are dominated by quantization noise. Changing the filter notch and cutoff frequency in the quantization-noise dominated region results in a more dramatic improvement in noise performance than it does in the device-noise dominated region as shown in Tables I and II. Furthermore, quantization noise is added after the PGA, so effective resolution is largely independent of gain for the higher filter notch frequencies. Meanwhile, device noise is added in the PGA and, therefore, effective resolution reduces at high gains for lower notch frequencies. Additionally, in the device-noise dominated region, the output noise is largely independent of reference voltage while in the quantization-noise dominated region, the noise is proportional to the value of the reference. Noise numbers in the device noise dominated region will be higher than those in the Table I for BUFFER $=1$ (at a gain of $128,10 \mathrm{~Hz}$ notch rms noise will be 500 nV ). It is possible to do post-filtering on the device to improve the output data rate for a given -3 dB frequency and also to further reduce the output noise.
At the lower filter notch settings (below 60 Hz for $\mathrm{f}_{\mathrm{CLK} \text { IN }}=2.4576 \mathrm{MHz}$ and below 25 Hz for $\mathrm{f}_{\mathrm{CLK} \text { IN }}=1 \mathrm{MHz}$ ), the no missing codes performance of the device is at the 24-bit level. At the higher settings, more codes will be missed until at 1 kHz notch setting for $\mathrm{f}_{\mathrm{CLK} \mathrm{IN}}=2.4576 \mathrm{MHz}\left(400 \mathrm{~Hz}\right.$ for $\left.\mathrm{f}_{\text {CLK IN }}=1 \mathrm{MHz}\right)$, ho missing codes performance is only guaranteed to the 12-bit level.

Table I. Output Noise/Effective Resolution vs. Gain and First Notch Frequency for $\mathrm{f}_{\mathrm{CLK} \text { IN }}=\mathbf{2 . 4 5 7 6} \mathbf{~ M H z}$, BUFFER $=0$

| Filter First <br> Notch \& O/P <br> Data Rate | $\begin{aligned} & -3 \mathrm{~dB} \\ & \text { Frequency } \end{aligned}$ | 2. Typical Output RMS Noise in $\mu \mathrm{V}$ (Effective Resolution in Bits) |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Gain of 1 |  | $\begin{gathered} \text { Gain of } \\ 2 \end{gathered}$ |  | Gain of$4$ |  | Gain of 8 |  | Gain of 16 |  | Gain of 32 |  | Gain of 64 |  | Gain of 128 |  |
| 5 Hz | 1.31 Hz | 1.2 | (22) | 0.7 | (22) | 0.4 | (21.5) | 0.3 | (21) | 0.3 | (20) | 0.3 | (19) | 0.3 | (18) | 0.3 | (17) |
| 10 Hz | 2.62 Hz | 1.7 | (21.5) | 1.0 | (21.5) | 0.5 | (21.5) | 0.36 | (20.5) | 0.33 | (20) | 0.33 | (19) | 0.33 | (18) | 0.33 | (17) |
| 25 Hz | 6.55 Hz | 4.9 | (20) | 2.2 | (20) | 1.2 | (20) | 0.60 | (20) | 0.36 | (19.5) | 0.36 | (18.5) | 0.36 | (17.5) | 0.36 | (16.5) |
| 30 Hz | 7.86 Hz | 6.1 | (19.5) | 2.4 | (20) | 1.2 | (20) | 0.84 | (19.5) | 0.5 | (19.5) | 0.4 | (18.5) | 0.4 | (17.5) | 0.4 | (16.5) |
| 50 Hz | 13.1 Hz | 7.5 | (19.5) | 3.8 | (19.5) | 2.0 | (19.5) | 1.0 | (19.5) | 0.6 | (19) | 0.5 | (18.5) | 0.5 | (17.5) | 0.45 | (16.5) |
| 60 Hz | 15.72 Hz | 8.5 | (19) | 4.1 | (19) | 2.1 | (19) | 1.1 | (19) | 0.6 | (19) | 0.5 | (18.5) | 0.5 | (17.5) | 0.45 | (16.5) |
| 100 Hz | 26.2 Hz | 13 | (18.5) | 6.4 | (18.5) | 3.7 | (18.5) | 1.8 | (18.5) | 1.1 | (18) | 0.9 | (17.5) | 0.65 | (17) | 0.65 | (16.5) |
| 250 Hz | 65.5 Hz | 130 | (15) | 75 | (15) | 25 | (15.5) | 12 | (15.5) | 7.5 | (15.5) | 4.0 | (15.5) | 2.7 | (15) | 1.7 | (14.5) |
| 500 Hz | 131 Hz | 600 | (13) | 260 | (13) | 140 | (13) | 70 | (13) | 35 | (13) | 25 | (12.5) | 15 | (12.5) | 8 | (12.5) |
| 1 kHz | 262 Hz | 2,850 | (11) | 1,430 | (11) | 700 | (11) | 290 | (11) | 180 | (11) | 120 | (11) | 63 | (10.5) | 35 | (10) |

Table II. Output Noise/Effective Resolution vs. Gain and First Notch Frequency for $\mathrm{f}_{\text {CLK IN }}=1 \mathrm{MHz}$, BUFFER $=0$

| Filter First <br> Notch \& O/P <br> Data Rate | $-3 \mathrm{~dB}$ <br> Frequency | Typical Output RMS Noise in $\mu \mathrm{V}$ (Effective Resolution in Bits) |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Gain of 1 |  | $\begin{gathered} \text { Gain of } \\ 2 \end{gathered}$ |  | $\begin{gathered} \text { Gain of } \\ 4 \end{gathered}$ |  | Gain of 8 |  | Gain of 16 |  | $\begin{aligned} & \text { Gain of } \\ & 32 \end{aligned}$ |  | Gain of$64$ |  | Gain of$128$ |  |
| 2 Hz | 0.52 Hz | 1.2 | (22) | 0.7 | (22) | 0.4 | (21.5) | 0.3 | (21) | 0.3 | (20) | 0.3 | (19) | 0.3 | (18) | 0.3 | (17) |
| 4 Hz | 1.05 Hz | 1.7 | (21.5) | 1.0 | (21.5) | 0.5 | (21.5) | 0.36 | (20.5) | 0.33 | (20) | 0.33 | (19) | 0.33 | (18) | 0.33 | (17) |
| 10 Hz | 2.62 Hz | 4.9 | (20) | 2.2 | (20) | 1.2 | (20) | 0.60 | (20) | 0.36 | (19.5) | 0.36 | (18.5) | 0.36 | (17.5) | 0.36 | (16.5) |
| 25 Hz | 6.55 Hz | 8.5 | (19) | 4.1 | (19) | 2.1 | (19) | 1.1 | (19) | 0.6 | (19) | 0.5 | (18.5) | 0.5 | (17.5) | 0.45 | (16.5) |
| 30 Hz | 7.86 Hz | 10.2 | (19) | 4.9 | (19) | 2.6 | (19) | 1.3 | (19) | 0.8 | (18.5) | 0.65 | (18) | 0.65 | (17) | 0.5 | (16) |
| 50 Hz | 13.1 Hz | 22.5 | (18) | 11.2 | (18) | 5.6 | (18) | 2.7 | (18) | 1.7 | (17.5) | 1.2 | (17) | 0.85 | (16.5) | 0.75 | (15.5) |
| 60 Hz | 15.72 Hz | 31 | (17.5) | 16 | (17.5) | 7.6 | (17.5) | 3.7 | (17.5) | 2.3 | (17) | 1.5 | (16.5) | 1.0 | (16) | 0.85 | (15.5) |
| 100 Hz | 26.2 Hz | 130 | (15) | 75 | (15) | 25 | (15.5) | 12 | (15.5) | 7.5 | (15.5) | 4.0 | (15.5) | 2.7 | (15) | 1.7 | (14.5) |
| 200 Hz | 52.4 Hz | 600 | (13) | 260 | (13) | 140 | (13) | 70 | (13) | 35 | (13) | 25 | (12.5) | 15 | (12.5) | 8 | (12.5) |
| 400 Hz | 104.8 Hz | 2,850 | (11) | 1,430 | (11) | 700 | (11) | 290 | (11) | 180 | (11) | 120 | (11) | 63 | (10.5) | 35 | (10) |

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## AD7714-3 Output Noise

Table III shows the output rms noise and effective resolution for some typical notch and -3 dB frequencies for the AD7714-3 with $\mathrm{f}_{\text {CLK IN }}=2.4576 \mathrm{MHz}$ while Table IV gives the information for $\mathrm{f}_{\text {CLK IN }}=1 \mathrm{MHz}$. The numbers given are for the bipolar input ranges with a $\mathrm{V}_{\mathrm{REF}}$ of +1.25 V and BUFFER $=0$. These numbers are typical and are generated at an analog input voltage of 0 V . The numbers in brackets in each table are for the effective resolution of the part (rounded to the nearest 0.5 LSB ). The effective resolution of the device is defined as the ratio of the output rms noise to the input full-scale (i.e., $2 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}$ ). It should be noted that it is not calculated using peak-to-peak output noise numbers. Peak-to-peak noise numbers can be up to 6.6 times the rms numbers while effective resolution numbers based on peak-to-peak noise can be 2.5 bits below the effective resolution based on rms noise as quoted in the tables.
The output noise from the part comes from two sources. The first is the electrical noise in the semiconductor devices used in the implementation of the modulator (device noise). Secondly, when the analog input signal is converted into the digital domain, quantization noise is added. The device noise is at a low level and is largely independent of frequency. The quantization noise starts at an even lower level but rises rapidly with increasing frequency to become the dominant noise source. Consequently, lower filter notch settings (below 100 Hz approximately for $\mathrm{f}_{\mathrm{CLK} \mathrm{IN}}=2.4576 \mathrm{MHz}$ and below 40 Hz approximately for $\mathrm{f}_{\mathrm{CLK} \text { IN }}=1 \mathrm{MHz}$ ) tend to be device noise dominated while higher notch settings are dominated by quantization noise. Changing the filter notch and cutoff frequency in the quantization noise dominated region results in a more dramatic improvement in noise performance than it does in the device-noise dominated region as shown in Tables III and IV. Furthermore, quantization noise is added after the PGA, so effective resolution is largely independent of gain for the higher filter notch frequencies. Meanwhile, device noise is added in the PGA and, therefore, effective resolution suffers a little at high gains for lower notch frequencies. Additionally, in the device-noise dominated region, the output noise is largely independent of reference voltage while in the quantization-noise dominated region, the noise is proportional to the value of the reference. Noise numbers in the device noise dominated region will be higher than those in the Table III for BUFFER = 1 (at a gain of $128,10 \mathrm{~Hz}$ notch rms noise will be 500 nV ). It is possible to do post-filtering on the device to improve the output data rate for a given -3 dB frequency and also to further reduce the output noise (see Digital Filtering section).
At the lower filter notch settings (below 60 Hz for $\mathrm{f}_{\mathrm{CLK} \text { IN }}=2.4576 \mathrm{MHz}$ and below 25 Hz for $\mathrm{f}_{\mathrm{CLKIN}}=1 \mathrm{MHz}$ ), the no missing codes performance of the device is at the 24 -bit level. At the higher settings, more codes will be missed until at 1 kHz notch setting for $\mathrm{f}_{\mathrm{CLK} \text { IN }}=2.4576 \mathrm{MHz}\left(400 \mathrm{~Hz}\right.$ for $\mathrm{f}_{\text {CLK IN }}=1 \mathrm{MHz}$ ), no missing codes performance is only guaranteed to the 12-bit level.

Table III. Output Noise/Effective Resolution vs. Gain and First Notch Frequency for $\mathrm{f}_{\mathrm{CLK} \mathrm{IN}}=2.4576 \mathrm{MHz}$, BUFFER $=0$

| Filter First <br> Notch \& O/P <br> Data Rate | $-3 \mathrm{~dB}$ <br> Frequency | Typical Output RMS Noise in $\mu \mathrm{V}$ (Effective Resolution in Bits) |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Gain of 1 |  | Gain of 2 |  | $\begin{gathered} \text { Gain of } \\ 4 \end{gathered}$ |  | $\begin{gathered} \text { Gain of } \\ 8 \end{gathered}$ |  | Gain of 16 |  | Gain of$32$ |  | $\begin{aligned} & \text { Gain of } \\ & 64 \end{aligned}$ |  | Gain of 128 |  |
| 5 Hz | 1.31 Hz | 1.2 | (21) | 0.7 | (21) | 0.4 | (20.5) | 0.3 | (20) | 0.3 | (19) | 0.3 | (18) | 0.3 | (17) | 0.3 | (16) |
| 10 Hz | 2.62 Hz | 1.7 | (20.5) | 1.0 | (20.5) | 0.5 | (20.5) | 0.36 | (19.5) | 0.33 | (19) | 0.33 | (18) | 0.33 | (17) | 0.33 | (16) |
| 25 Hz | 6.55 Hz | 4.9 | (19) | 2.2 | (19) | 1.2 | (19) | 0.60 | (19) | 0.36 | (18.5) | 0.36 | (17.5) | 0.36 | (16.5) | 0.36 | (15.5) |
| 30 Hz | 7.86 Hz | 5.6 | (19) | 2.4 | (19) | 1.2 | (19) | 0.84 | (18.5) | 0.5 | (18.5) | 0.4 | (17.5) | 0.4 | (16.5) | 0.4 | (15.5) |
| 50 Hz | 13.1 Hz | 7.5 | (18.5) | 3.8 | (18.5) | 2.0 | (18.5) | 1.0 | (18.5) | 0.6 | (18) | 0.5 | (17.5) | 0.5 | (16.5) | 0.45 | (15.5) |
| 60 Hz | 15.72 Hz | 8.5 | (18) | 4.1 | (18) | 2.1 | (18) | 1.1 | (18) | 0.6 | (18) | 0.5 | (17.5) | 0.5 | (16.5) | 0.45 | (15.5) |
| 100 Hz | 26.2 Hz | 13 | (17.5) | 6.4 | (17.5) | 2.9 | (17.5) | 1.5 | (17.5) | 1.1 | (17) | 0.7 | (17) | 0.65 | (16) | 0.65 | (15) |
| 250 Hz | 65.5 Hz | 53 | (15.5) | 28 | (15.5) | 12 | (15.5) | 8.6 | (15) | 3.9 | (15) | 3.7 | (14) | 1.9 | (14) | 1.4 | (14) |
| 500 Hz | 131 Hz | 240 | (13.5) | 150 | (13) | 80 | (13) | 35 | (13) | 22 | (13) | 14 | (12.5) | 8.7 | (12) | 8 | (11.5) |
| 1 kHz | 262 Hz | 1400 | (11) | 610 | (11) | 370 | (10.5) | 230 | (10.5) | 125 | (10.5) | 70 | (10) | 40 | (10) | 22 | (10) |

Table IV. Output Noise/Effective Resolution vs. Gain and First Notch Frequency for $f_{\text {cLK IN }}=1 \mathrm{MHz}$, BUFFER $=0$

| Filter First Notch \& O/P Data Rate | $\begin{aligned} & -3 \mathrm{~dB} \\ & \text { Frequency } \end{aligned}$ | Typical Output RMS Noise in $\mu \mathrm{V}$ (Effective Resolution in Bits) |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Gain of 1 |  | $\underset{2}{\text { Gain of }}$ |  | Gain of$4$ |  | Gain of$8$ |  | $\begin{gathered} \text { Gain of } \\ 16 \end{gathered}$ |  | Gain of$32$ |  | Gain of 64 |  | Gain of 128 |  |
| 2 Hz | 0.52 Hz | 1.2 | (21) | 0.7 | (21) | 0.4 | (20.5) | 0.3 | (20) | 0.3 | (19) | 0.3 | (18) | 0.3 | (17) | 0.3 | (16) |
| 4 Hz | 1.05 Hz | 1.7 | (20.5) | 1.0 | (20.5) | 0.5 | (20.5) | 0.36 | (19.5) | 0.33 | (19) | 0.33 | (18) | 0.33 | (17) | 0.33 | (16) |
| 10 Hz | 2.62 Hz | 4.9 | (19) | 2.2 | (19) | 1.2 | (19) | 0.60 | (19) | 0.36 | (18.5) | 0.36 | (17.5) | 0.36 | (16.5) | 0.36 | (15.5) |
| 25 Hz | 6.55 Hz | 7.8 | (18.5) | 4.1 | (18) | 2.1 | (18) | 1.1 | (18) | 0.6 | (18) | 0.5 | (17.5) | 0.5 | (16.5) | 0.45 | (15.5) |
| 30 Hz | 7.86 Hz | 10.2 | (18) | 4.9 | (18) | 2.1 | (18) | 1.1 | (18) | 0.8 | (17.5) | 0.65 | (17) | 0.65 | (16) | 0.5 | (15) |
| 50 Hz | 13.1 Hz | 22.5 | (17) | 11.2 | (17) | 4.4 | (17) | 2.3 | (17) | 1.7 | (16.5) | 1.2 | (16) | 0.85 | (15.5) | 0.75 | (14.5) |
| 60 Hz | 15.72 Hz | 31 | (16.5) | 16 | (16.5) | 6.0 | (16.5) | 3.2 | (16.5) | 2.3 | (16) | 1.5 | (15.5) | 1.0 | (15) | 0.85 | (14.5) |
| 100 Hz | 26.2 Hz | 53 | (15.5) | 28 | (15.5) | 12 | (15.5) | 8.6 | (15) | 3.9 | (15) | 3.7 | (14) | 1.9 | (14) | 1.4 | (14) |
| 200 Hz | 52.4 Hz | 240 | (13.5) | 150 | (13) | 80 | (13) | 35 | (13) | 22 | (13) | 14 | (12.5) | 8.7 | (12) | 8 | (11.5) |
| 400 Hz | 104.8 Hz | 1400 | (11) | 610 | (11) | 370 | (10.5) | 230 | (10.5) | 125 | (10.5) | 70 | (10) | 40 | (10) | 22 | (10) |

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## On-Chip Registers

The AD7714 contains eight on-chip registers which can be accessed via the serial port of the part. The first of these is a Communications Register which controls the channel selection, decides whether the next operation is a read or write operation and also decides which register the next read or write operation accesses. The $\overline{\text { DRDY }}$ status is also available by reading from the Communications Register. The second register is a Mode Register which determines calibration mode and gain setting. The third register is labelled the Filter High Register and this determines the word length, bipolar/unipolar operation and contains the upper 4 bits of the filter selection word. The fourth register is labelled the Filter Low Register and contains the lower 8 bits of the filter selection word. The fifth register is a Test Register which is accessed when testing the device. The sixth register is the Data Register from which the output data from the part is accessed. The final two registers are calibration registers; one is the Calibration Zero-Scale Register and the other is the Calibration Full-Scale Register. The registers are discussed in more detail in the following sections.
Communications Register ( $R S 2-R S 0=0,0,0$ )
The Communications Register is an eight bit register from which data can either be read or to which data can be written. On powerup or after a $\overline{\text { RESET }}$, the AD7714 is waiting for a write operation to the Communications Register. This is the default state of the interface, and in situations where the interface sequence is lost, if enough writes to the device (at least four bytes) take place with DIN high, the AD7714 returns to its default state. Table V outlines the bit designations for the Communications Register.

Table V. Communications Register


Table VI. Channel Selection

| CH2 | CH1 | CH0 | AIN(+) | AIN(-) | Type | Calibration Register Pair |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| 0 | 0 | 0 | AIN1 | AIN6 | Pseudo Differential | Register Pair 0 |
| 0 | 0 | 1 | AIN2 | AIN6 | Pseudo Differential | Register Pair 1 |
| 0 | 1 | 0 | AIN3 | AIN6 | Pseudo Differential | Register Pair 2 |
| 0 | 1 | 1 | AIN4 | AIN6 | Pseudo Differential | Register Pair 2 |
| 1 | 0 | 0 | AIN1 | AIN2 | Fully Differential | Register Pair 0 |
| 1 | 0 | 1 | AIN3 | AIN4 | Fully Differential | Register Pair 1 |
| 1 | 1 | 0 | AIN5 | AIN6 | Fully Differential | Register Pair 2 |
| 1 | 1 | 1 | AIN6 | AIN6 | Test Mode | Register Pair 2 |

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Mode Register (RS2-RS0 = 0, 0, 1); Power On/Reset Status: 00 Hex
The Mode Register is an eight bit register from which data can either be read or to which data can be written. Table VII outlines the bit designations for the Mode Register.

Table VII. Mode Register

| MD2 | MD1 | MD0 | G2 | G1 | G0 | BO | FSYNC |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |


| MD2 | MD1 | MD0 | Operating Mode |
| :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | Normal Mode; this is the normal mode of operation of the device whereby the device is performing normal conversions. This is the default condition of these bits after Power-On or RESET. |
| 0 | 0 | 1 | Self-Calibration; this activates self-calibration on the channel selected by $\mathrm{CH} 2, \mathrm{CH} 1$ and CH 0 of the Communications Register. This is a one step calibration sequence and when complete the part returns to Normal Mode. The $\overline{\text { DRDY }}$ output or bit indicates when this self-calibration is complete and when a new valid word is available in the data register. For this calibration type, the zero-scale calibration is done internally on shorted (zeroed) inputs and the full-scale calibration is done internally on $\mathrm{V}_{\text {REF }}$. |
| 0 | 1 | 0 | Zero-Scale System Calibration; this activates zero-scale system calibration on the channel selected by $\mathrm{CH} 2, \mathrm{CH} 1$ and CH0 of the Communications Register. Calibration is performed on the analog input voltage provided at the analog input during this calibration sequence. The $\overline{\mathrm{DRDY}}$ output or bit indicates when this zero-scale calibration is complete and the part returns to Normal Mode. |
| 0 | 1 | 1 | Full-Scale System Calibration; this activates full-scale system calibration on the selected input channel. Calibration is performed on the analog input voltage provided at the analog input during this calibration sequence. Once again, $\overline{\mathrm{DRDY}}$ indicates when this full-scale calibration is complete. When this calibration is complete, the part returns to Normal Mode. |
| 1 | 0 | 0 | System-Offset Calibration; this activates system-offset calibration on the channel selected by $\mathrm{CH} 2, \mathrm{CH} 1$ and CH 0 of the Communications Register. This is a one step calibration sequence and when complete the part returns to Normal Mode with $\overline{\mathrm{DRDY}}$ indicating when this system offset calibration is complete. For this calibration type, the zero-scale calibration is done on the selected input channel and the full-scale calibration is done internally on $\mathrm{V}_{\text {REF }}$. |
| 1 | 0 | 1 | Background Calibration; this activates background calibration on the channel selected by $\mathrm{CH} 2, \mathrm{CH} 1$ and CH 0 of the Communications Register. If the background calibration mode is on, the AD7714 provides continuous selfcalibration of the shorted (zeroed) inputs. This calibration takes place as part of the conversion sequence, extending the conversion time and reducing the word rate by a factor of six. Its major advantage is that the user does not have to worry about recalibrating the offset of the device when there is a change in the ambient temperature or supplies. In this mode, the shorted (zeroed) inputs, as well as the analog input voltage, are continuously monitored and the calibration registers of the device are automatically updated. Because the background calibration does not perform fullscale calibrations, a full-scale self-calibration should be performed before placing the part in background calibration mode. |
| 1 | 1 | 0 | Zero-Scale Self-Calibration; this activates zero-scale self-calibration on the channel selected by $\mathrm{CH} 2, \mathrm{CH} 1$ and CH 0 of the Communications Register. This zero-scale calibration is done internally on shorted (zeroed) inputs. This is a one step calibration sequence and when complete the part returns to Normal Mode. The DRDY output or bit indicates when this zero-scale self-calibration is complete. |
| 1 | 1 | 1 | Full-Scale Self-Calibration; this activates full-scale self-calibration on the channel selected by $\mathrm{CH} 2, \mathrm{CH} 1$ and CH 0 of the Communications Register. This full-scale calibration is done internally on $\mathrm{V}_{\mathrm{REF}}$. This is a one step calibration sequence and when complete the part returns to Normal Mode. The DRDY output indicates when this fullscale self-calibration is complete. |
| G2 | G1 | G0 | Gain Setting |
| 0 | 0 | 0 |  |
| 0 | 0 | 1 | 2 |
| 0 | 1 | 0 | 4 ** |
| 0 | 1 | 1 |  |
| 1 | 0 | 0 | 16 |
| 1 | 0 | 1 | 32 |
| 1 | 1 | 0 | 64 |
| 1 | 1 | 1 | 128 |
| BO FSYNC |  |  | Burn Out Current. A 0 in this bit turns off the on-chip burn out currents. This is the default (Power-On or RESET) status of this bit. A 1 in this bit activates the burn out currents. <br> Filter Synchronization. When this bit is high, the nodes of the digital filter, the filter control logic and the calibration control logic are reset, and the analog modulator is also held in its reset state. When this bit goes low, valid data is available in $3 \times 1 /$ (output update rate), i.e., the settling time of the filter. |

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Filter Registers. Power On/Reset Status: Filter High Register: 01 Hex. Filter Low Register: 40 Hex
There are two 8-bit Filter Registers on the AD7714 from which data can either be read or to which data can be written. Tables VIII and IX outline the bit designations for the Filter Registers.

Table VIII. Filter High Register (RS2-RS0 $=0,1,0$ )

| $\overline{\mathrm{B}} / \mathrm{U}$ | WL | BST | 0 | FS11 | FS10 | FS9 | FS8 |
| :--- | :--- | :---: | :---: | :---: | :---: | :---: | :---: |

Table IX. Filter Low Register (RS2-RS0 $=\mathbf{0}, 1,1$ )

| FS7 | FS6 | FS5 | FS4 | FS3 | FS2 | FS1 | FS0 |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |


| $\overline{\mathrm{B}} / \mathrm{U}$ | Bipolar/Unipolar Operation. A 0 in this bit selects Bipolar Operation. This is the default (Power-On or $\overline{\text { RESET }}$ ) status of this bit. A 1 in this bit selects unipolar operation. |
| :---: | :---: |
| WL | Word Length. A 0 in this bit selects 16 -bit word length when reading from the data register (i.e., $\overline{\text { DRDY }}$ returns high after 16 serial clock cycles). This is the default (Power-On or RESET) status of this bit. A 1 in this bit selects 24 -bit word length. |
| BST | Current Boost. A 0 in this bit reduces the current taken by the analog front-end. When the part is operated with $\mathrm{f}_{\mathrm{CLK} \text { IN }}=1 \mathrm{MHz}$, this bit should be 0 to reduce the curtent drawn from $\mathrm{AV}_{\mathrm{DD}}$. When the AD 7714 is operated from $\mathrm{f}_{\mathrm{CLK} \text { IN }}=2.4576 \mathrm{MHz}$ with gains of 8 to 128 , thís bit needs to be 1 to ensure correct operation of the device. The Power-On or RESET status of this bit is 0 . |
| 0 | To ensure correct operation of the part, a 0 must be written to thi |
| FS11-FS0 | Filter Selection. The on-chip digital filter provides a Sinc (or $\left.(\operatorname{Sin} x / x)^{3}\right)$ filter response. The 12-bits of data programmed into these bits determine the filter cut-off frequency, the position of the first notch of the filter and the data rate for the part In association with the gain selection, it also determines the output noise (and hence the effective resolution) of the device. <br> The first notch of the filter occurs at a frequency determined by the relationship: filter first notch frequency $=\left(f_{C L K I N} / 128\right) /$ code where code is the decimal equivalent of the code in bits FS0 to FS11 and is in the range 19 to 4,000 . With the nominal $\mathrm{f}_{\text {CLK IN }}$ of 2.4576 MHz , this results in a first notch frequency range from 4.8 Hz to 1.01 kHz . To ensure correct operation of the AD7714, the value of the code loaded to these bits must be within this range. Failure to do this will result in unspecified operation of the device. <br> Changing the filter notch frequency, as well as the selected gain, impacts resolution. Tables I through IV show the effect of the filter notch frequency and gain on the effective resolution of the AD7714. The output data rate (or effective conversion time) for the device is equal to the frequency selected for the first notch of the filter. For example, if the first notch of the filter is selected at 50 Hz , then a new word is available at a 50 Hz rate or every 20 ms . If the first notch is at 1 kHz , a new word is available every 1 ms . <br> The settling-time of the filter to a full-scale step input change is worst case $4 \times 1$ (output data rate). For example, with the first filter notch at 50 Hz , the settling time of the filter to a full-scale step input change is 80 ms max. If the first notch is at 1 kHz , the settling time of the filter to a full-scale input step is 4 ms max. This settling-time can be reduced to $3 \times 1$ (output data rate) by synchronizing the step input change to a reset of the digital filter. In other words, if the step input takes place with the $\overline{\text { SYNC }}$ input low or the FSYNC bit high, the settling-time time will be $3 \times 1$ (output data rate) from when SYNC returns high or FSYNC returns low. If a change of channel takes place, the settling-time is $3 \times 1$ (output data rate) regardless of the $\overline{\text { SYNC }}$ or FSYNC status as the part issues an internal SYNC command when requested to change channels. <br> The -3 dB frequency is determined by the programmed first notch frequency according to the relationship: filter -3 dB frequency $=0.262 \times$ first notch frequency. |

## Test Register ( $R S 2-R S 0=1,0,0$ )

The part contains a Test Register which is used in testing the device. The user is advised not to change the status of any of the bits in this register from the default (Power-On or RESET) status of all 0 s as the part will be placed in one of its test modes and will not operate correctly. If the part enters one of its test modes, exercising RESET will exit the part from the mode.

[^39]Data Register (RS2-RS0 = 1, 0, 1)
The Data Register on the part is a read-only register which contains the most up-to-date conversion result from the AD7714. The register can be programmed to be either 16 bits or 24 bits wide, determined by the status of the WL bit of the Mode Register. If an attempt is made to write to this register, the 16 or 24 bits of data will not actually be written to any location of the AD7714.

Calibration Zero-Scale Register ( $R S 2-$ RSO $=1,1,0$ )
The AD7714 contains 3 zero-scale calibration registers, labelled Register 0 to Register 2. Each of these registers is a 24-bit read/ write register and 24 bits must be written; otherwise no data will be transferred to the register. The register is used in conjunction with the associated full-scale calibration register to form a register pair. These register pairs are associated with input channel pairs as outlined in Table VI.

There is a possibility that after accessing the calibration registers (either read or write operation), the first output data read from the part contain incorrect data. In addition, a read or write operation to the calibration register should not be attempted while a calibration is in progress. These eventualities can be avoided by taking either the SYNC input low or the FSYNC bit of the Mode Register high before the calibration register operation and taking them either high or low respectively after the operation is complete.

Calibration Full-Scale Register (RS2-RS0 $=1,1,1$ )
The AD7714 contains 3 full-scale calibration registers, labelled Register 0 to Register 2. Each of these registers is a 24 -bit read/write register and 24 bits must be written, otherwise no data will be transferred to the register. The register is used in conjunction with the associated zero scale calibration register to form a register pair. These register pairs are associated with input channel pairs as outlined in Table VI.
There is a possibility that after accessing the calibration registers (either read or write operation), the first output data read from the part will contain incorrect data. In addition, a read or write operation to the calibration register should not be attempted while a calibration is in progress. These eventualities can be avoided by taking either the SYNC input low or the FSYNC bit of the Mode Register high before the calibration register operation and taking them either high or low respectively after the operation is complete.

## CIRCUIT DESCRIPTION

The AD7714 is a sigma-delta A/D converter with on-chip digital filtering, intended for the measurement of wide dynamic range, low frequency signals such as those in weigh-scale, industrial control or process control applications. It contains a sigmadelta (or charge-balancing) ADC, a calibration microcontroller with on-chip static RAM, a clock oscillator, a digital filter and a bidirectional serial communications port. The part consumes only $500 \mu \mathrm{~A}$ of power supply current, making it ideal for battery-powered or loop-powered instruments. The part comes in two versions, the AD7714-5 which is specified for operation from $\mathrm{a}+5 \mathrm{~V}$ analog supply $\left(\mathrm{AV}_{\mathrm{DD}}\right)$ and the AD7714-3 which is specified for operation from a +3 V analog supply. The AD7714-5 can be operated with a digital supply ( $\mathrm{DV} \mathrm{VD}_{\mathrm{DD}}$ ) voltage of +3 V or +5 V .

The part contains three programmable-gain fully differential analog input channels which can be reconfigured as five pseudodifferential inputs. The gain range on all channels is from 1 to 128 allowing the part to accept unipolar signals of between 0 mV to +20 mV and 0 V to +2.5 V or bipolar signals in the range from $\pm 20 \mathrm{mV}$ to $\pm 2.5 \mathrm{~V}$ when the reference input voltage equals +2.5 V . With a reference voltage of +1.25 V , the input ranges are from 0 mV to +10 mV to 0 V to +1.25 V in unipolar mode and from $\pm 10 \mathrm{mV}$ to $\pm 1.25 \mathrm{~V}$ in bipolar mode.
The input signal to the selected analog input channel is continuously sampled at a rate determined by the frequency of the master clock, MCLK IN, and the selected gain. A chargebalancing A/D converter (Sigma-Delta Modulator) converts the sampled signal into a digital pulse train whose duty cycle contains the digital information. The programmable gain function on the analog input is also incorporated in this sigma delta modulator with the input sampling frequency being modified to give the higher gains. A Sinc ${ }^{3}$ digital low-pass filter processes
the output of the sigma-delta modulator and updates the output register at a fate determined by the first notch frequency of this filter. The output data can be read from the serial port randomly or periodically at any rate up to the output register update rate. The first notch of this digital filter (and hence its -3 dB frequency) can be programmed via the filter high and filter low registers. With a master clock frequency of 2.4576 MHz , the programmable range for this first notch frequency is from 4.8 Hz to 1.01 kHz giving a programmable range for the -3 dB frequency of 1.26 Hz to 265 Hz .

The basic connection diagram for the part is shown in Figure 2. This shows both the $A V_{D D}$ and $D V_{D D}$ pins of the AD7714 being driven from the analog +3 V or +5 V supply. Some applications will have $A V_{D D}$ and $D V_{D D}$ driven from separate supplies. In the connection diagram shown, the AD7714's analog inputs are configured as three fully differential inputs. The part is set up for unbuffered mode on the these analog inputs. An AD780, precision +2.5 V reference, provides the reference source for the part. On the digital side, the part is configured for three-wire operation with $\overline{\mathrm{CS}}$ tied to DGND. A quartz crystal or ceramic resonator provides the master clock source for the part.
The AD7714 provides a number of calibration options which can be programmed via the MD2, MD1 and MD0 bits of the Mode Register. A calibration cycle may be initiated at any time by writing to these bits of the Mode Register. The part can perform self-calibration using the on-chip calibration microcontroller and SRAM to store calibration parameters. Other system components may also be included in the calibration loop to remove offset and gain errors in the input channel using the system calibration mode. Another option is a background calibration mode where the part continuously performs internal zero-scale calibrations and updates the calibration coefficients. Using the part in this mode, the user does not have to worry

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Figure 2. Basic Connection Diagram
about issuing periodic calibration commands to the device or ask the device to recalibrate when there is a change in the ambient temperature or power supply voltage. This automatic removal of offset errors is achieved at the expense of output update rate which is reduced by a factor of six. Using the part in background calibration mode automatically removes offset errors but not full-scale errors. A full-scale self-calibration should be performed before entering the background calibration mode. The residual gain drift in background calibration mode is $2 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$.
The AD7714 gives the user access to the on-chip calibration registers allowing the microprocessor to read the device's calibration coefficients and also to write its own calibration coefficients to the part from prestored values in $E^{2} P R O M$. This gives the microprocessor much greater control over the AD7714's calibration procedure. It also means that the user can verify that the device has performed its calibration correctly by comparing the coefficients after calibration with prestored values in $\mathrm{E}^{2}$ PROM. Table X details the calibration options and sequences available on the AD7714. For the table, Sel Gain refers to the selected operating gain.

## DIGITAL INTERFACE

The AD7714's serial interface consists of five signals, $\overline{\mathrm{CS}}$, SCLK, DIN, DOUT and DRDY. The DIN line is used for

Table X. Calibration Sequences

| Calibration Type | MD2, MD1, MDO | Calibration Sequence | Duration |
| :--- | :--- | :--- | :--- |
| Self Calibration | $0,0,1$ | Internal ZS Cal @ Sel Gain + | $9 \times 1 /$ Output Rate |
|  |  | Internal FS Cal @ Sel Gain |  |
| ZS System Calibration | $0,1,0$ | ZS Cal on AIN @ Sel Gain | $3 \times 1 /$ Output Rate |
| FS System Calibration | $0,1,1$ | FS Cal on AIN @ Sel Gain | $3 \times 1 /$ Output Rate |
| System-Offset Calibration | $1,0,0$ | ZS Cal on AIN @ Sel Gain + | $9 \times 1 /$ Output Rate |
|  |  | Internal FS Cal @Sel Gain |  |
| Background Calibration | $1,0,1$ | Internal ZS Cal @ Sel Gain | $6 \times 1 /$ Output Rate |
| ZS Self Calibration | $1,1,0$ | Internal ZS Cal @ Sel Gain | $3 \times 1 /$ Output Rate |
| FS Self Calibration | $1,1,1$ | Internal FS Cal @ Sel Gain | $3 \times 1 /$ Output Rate |

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## AD7714

transferring data into the on-chip registers while the DOUT line is used for accessing data from the on-chip registers. SCLK is the serial clock input for the device and all data transfers (either on DIN or DOUT) take place with respect to this SCLK signal. The DRDY line is used as a status signal to indicate when data is ready to be read from the AD7714's data register. DRDY goes low when a new data word is available in the output register. It is reset high when a read operation from the data register is complete. It also goes high prior to the updating of the output register to indicate when not to read from the device to ensure that a data read is not attempted while the register is being updated. $\overline{\mathrm{CS}}$ is used to select the device. It can be used to decode the AD7714 in systems where a number of parts are connected to the serial bus.
The AD7714 serial interface can operate in three-wire mode by tying the $\overline{\mathrm{CS}}$ input low. In this case, the SCLK, DIN and DOUT lines are used to communicate with the AD7714 and the status of $\overline{\text { DRDY }}$ can be obtained by interrogating the MSB of the Communications Register.

Figures 3 and 4 show timing diagrams for interfacing to the AD7714 with $\overline{\mathrm{CS}}$ used to decode the part. Figure 3 is for a read operation from the AD7714's output shift register while Figure 4 shows a write operation to the input shift register. Both diagrams are for the POL input at a logic high; for operation with the POL input at a logic high simply invert the SCLK waveform shown in the diagrams. It is possible to read the same data twice from the output register even though the $\overline{\text { DRDY }}$ line returns high after the first read operation. Care must be taken, however, to ensure that the read operations have been completed before the next output update is about to take place.
The serial interface can be reset by exercising the $\overline{\text { RESET }}$ input on the part. It can also be reset by writing a series of 1 s on the DIN input. If a logic 1 is written to the AD7714 DIN line for at least 32 serial clock cycles, the serial interface is reset. This ensures that in three-wire systems that if the interface gets lost either via a software error or by some glitch in the system, it can be reset back into a known state. This known state (which is • also where the interface returns to after a RESET) is that the part is expecting a write operation to the Communications Register.


Figure 3. Read Cycle Timing Diagram $(P O L=1)$


Figure 4. Write Cycle Timing Diagram $(P O L=1)$

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## FEATURES

12-Bit Sigma-Delta ADC
30 MHz Sampling Rate
468.75 kHz Output Word Rate

No Missing Codes
Low-Pass Digital Filter
Linear Phase
210 kHz Input Bandwidth
On-Chip Voltage Reference
Power Supplies: AV ${ }_{\text {DD }}$, DV ${ }_{D D}$ +5 V $\pm 5 \%$
Standby Mode
Flexible High Speed Serial Interface

## GENERAL DESCRIPTION

The AD7721 is a complete low power, 12-bit, sigma-delta ADC. The part operates from a +5 V supply and accepts a differential input of 0 V to 2.5 V or $\pm 1.25 \mathrm{~V}$. The analog input is continuously sampled by an analog modulator at a 30 MHz rate eliminating the need for external sample-and-hold circuitry. The modulator output is processed by two finite impulse response (FIR) digital filters in series. The on-chip filtering reduces the external antialias requirements to first order in most cases. Settling-time for a step input is $98.74 \mu \mathrm{~s}$ while the group delay for the filter is $49.37 \mu$ s.
The AD7721 provides 12-bit performance for input bandwidths up to 210 kHz . The part provides data at an output word rate of 468.75 kHz . The sample rate, filter corner frequency and output word rate are set by an external clock or crystal that is nominally set to 15 MHz .
Use of a single bit DAC in the modulator guarantees excellent linearity and dc accuracy. Endpoint accuracy is ensured by onchip calibration of offset and gain. This calibration procedure minimizes the part's zero-scale and full-scale errors.

The output data is accessed from the output register through a flexible serial port or a parallel port. This offers easy, high speed interfacing to modern microcontrollers and digital signal processors. The serial interface operates in external clocking (slave) mode. In this mode, an external serial clock and framing pulse must be provided to access the data from the output register.

## FUNCTIONAL BLOCK DIAGRAM



The part provides an on-chip, accurate 2.5 V reference. A REFIN/REFOUT function is provided that allows either this internal reference or an external system reference to be used as the reference source for the part.
CMOS construction ensures low power dissipation while a power-down mode, initiated by the STBY pin, reduces the idle power consumption to only $100 \mu \mathrm{~W}$.

## ORDERING INFORMATION

| Model | Temperature Range | Package Option ${ }^{\star}$ |
| :--- | :--- | :--- |
| AD7721AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-28$ |
| AD7721AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-28$ |
| AD7721SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-28$ |

$\star \mathrm{N}=$ Plastic DIP; $\mathrm{R}=0.3^{\prime \prime}$ Small Outline IC (SOIC); $\mathrm{Q}=$ Cerdip. For outline information see Package Information section.

[^40][^41]


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| Parameter | A Version | S Version | Units | Test Conditions/Comments |
| :--- | :--- | :--- | :--- | :--- |
| POWER SUPPLIES |  |  |  |  |
| AV $_{\text {DD }}$ | $4.75 / 5.25$ |  |  |  |
| DV $_{\text {DD }}$ | $4.75 / 5.25$ | $4.75 / 5.25$ | $\mathrm{~V} \min / \mathrm{V} \max$ |  |
| $\mathrm{I}_{\mathrm{DD}}$ (Total from AV |  |  |  |  |
| Power Consumption | 70 | $4.75 / 5.25$ | $\mathrm{~V} \min / \mathrm{V} \max$ |  |
| Power Consumption | 350 | 80 | $\mathrm{~mA} \max$ | $\mathrm{~mW} \max$ |

NOTES
${ }^{1}$ Operating temperature range is as follows: A Version: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; S Version: $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
${ }^{2}$ Applies after calibration at temperature of interest.
${ }^{3}$ Full-scale error applies to both positive and negative full-scale error. It excludes reference error. The ADC gain is calibrated w.r.t. the voltage on the REF2 pin. Specifications subject to change without notice.
TIMING CHARACTERISTICS ${ }^{1}\left(A_{D D}=+5 \mathrm{~V} \pm 5 \% ; \mathrm{DV}_{D D}=+5 \mathrm{~V} \pm 5 \% ; A G N D=D G N D=0 \mathrm{~V}, \mathrm{f}_{\mathrm{CLIIN}}=15 \mathrm{MHz}, \operatorname{REFIN}=+2.5 \mathrm{~V}\right)$


## NOTES

${ }^{1} \mathrm{t}_{7}$ and $\mathrm{t}_{14}$ are measured with the load circuit below and defined as the time required for an output to cross 0.4 V or 2 V .
${ }^{2} t_{9}$ and $t_{15}$ are derived from the measured time taken by the data outputs to change 0.5 V when loaded with the circuit shown below. The measured number is then extrapolated back to remove the effects of charging or discharging the 50 pF capacitor. This means that the time quoted in the Timing Characteristics is the true bus relinquish time of the part and, as such, is independent of external bus loading capacitance.


Figure 1. Load Circuit for Access Time and Bus Relinquish Time
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| Mnemonic | Function |
| :---: | :---: |
| $\mathrm{AV}_{\text {DD }}$ | Analog Positive Supply Voltage, $+5 \mathrm{~V} \pm 5 \%$. |
| AGND | Ground reference point for analog circuitry. |
| $\mathrm{DV}_{\mathrm{DD}}$ | Digital Supply Voltage, $+5 \mathrm{~V} \pm 5 \%$. |
| DGND | Ground reference point for digital circuitry. |
| VIN1 VIN2 | Analog Input. In unipolar operation, the analog input range on VIN1 is VIN2 to (VIN2 $+\mathrm{V}_{\text {REF }}$ ); for diffxerential (bipolar) operation, the analog input range on VIN1 is (VIN2 $\pm \mathrm{V}_{\text {REF }} / 2$ ). Alternatively, VIN2 can be connected to the internal reference in bipolar mode to give a single-ended input on VIN1 of (VREF $\pm$ VREF/2). VIN2 can be connected to the internal reference on chip by taking SINGIP high in the serial mode or writing to bit SINGIP in the parallel mode. The absolute analog input range must lie between 0 and $A V_{D D}$. The analog input is continu-; ously sampled and processed by the analog modulator. |
| REF1 <br> REF2 | Reference Pins. The AD7721 can operate with the on-board reference which has a nominal value of 2.5 V . Alternatively, an external reference can be used. There are three modes of operation: |

1. Using the internal reference. REF2 is used as the REFOUT. A 10 nF capacitor is required on REF2.
2. Using an external reference. REF1 is used as REFIN with the external reference source being connected to this pin. This reference is internally buffered thus, the reference sees a high impedance static load.
However, there will be an error added to this reference due to the offset voltage of the internal buffer amplifier, the offset having a value of $\pm 5 \mathrm{mV}$ maximum. A 10 nF capacitor is required from REF2 to ground. This method is useful when the external reference cannot drive a 10 nF load capacitor.
3. For system gain errors less than $0.02 \%$, REF1 is grounded and the external reference is connected to REF2. REF2 is directly connected to the on-chip modulator With this arrangement, a capacitor of value 10 nF is required between REF2 and ground.
XTAL

SDATA/DB11
STBY/DB0 DVAL/SYNC

The AD7721 operates with a 15 MHz crystal or with a 15 MHz external clock which is connected to the XTAL pin. The modulator samples the analog input on both phases of the clock, increasing the sampling rate to 30 MHz . Logic Output. In parallel mode, a falling edge indicates a new output word is available for transmission. $\overline{\text { DRDY }}$ will return high upon completion of a read operation. If a read operation does not occur between output updates, $\overline{\text { DRDY }}$ will become active for two clock cycles before the next output update. In serial mode, $\overline{\text { DRDY }}$ goes high for one SCLK cycle to indicate that data is available.
Chip Select. When the ADC is operated in parallel mode, this input selects the device. Note that serial mode operation is attained by tying $\overline{\mathrm{CS}}$ along with $\overline{\mathrm{RD}}$ and $\overline{\mathrm{WR}}$ to DGND.
Read. This digital input is used in conjunction with $\overline{\mathrm{CS}}$ to read data from the device when configured for parallel mode operation.
Write. This digital input is used in conjunction with $\overline{\mathrm{CS}}$ to write data to the device when the part is configured for parallel mode operation.
The function of these pins depends on the status of $\overline{\mathrm{CS}}, \overline{\mathrm{RD}}$ and $\overline{\mathrm{WR}}$. Driving $\overline{\mathrm{CS}}$ low along with $\overline{\mathrm{RD}}$ or $\overline{\mathrm{WR}}$ reads data or writes data to the device in the parallel mode. Tying $\overline{\mathrm{CS}}, \overline{\mathrm{RD}}$ and $\overline{\mathrm{WR}}$ low together configures the part for serial mode operation. NOTE: All three pins must be low for a minimum of two clock cycles of the internal clock ( 15 MHz ) before the part is configured for serial mode operation.

| MODE | SDATA/DB11 | $\overline{\text { RFS/DB10 }}$ | SCLK/DB9 | DB8 | CLKOUT/DB7 | SINGIP/DB6 | $\overline{\text { SYNC/DB5 }}$ |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Parallel <br> Serial | DB11 | SB10 | DB9 | DB8 | DB7 | DB6 | DB5 |


| MODE | DB4 | DB3 | UNI/DB2 | CAL/DB1 | STBY/DB0 | DVAL/ $\overline{\text { SYNC }}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Parallel <br> Serial | DB4 | DB3 | $\frac{\mathrm{DB} 2}{\mathrm{UNI}}$ | $\begin{gathered} \text { DB1 } \\ \text { CAL } \end{gathered}$ | $\begin{aligned} & \text { DB0 } \\ & \text { STBY } \end{aligned}$ | DVAL/ $\overline{S Y N C}$ DVAL |

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## SERIAL MODE ONLY

For serial mode operation, $\overline{\mathrm{CS}}, \overline{\mathrm{WR}}$ and $\overline{\mathrm{RD}}$ must be tied to DGND.

## SDATA/DB11

$\overline{\mathrm{RFS}} / \mathrm{DB} 10$

SCLK/DB9

CLKOUT/DB7

SINGIP/DB6
$\overline{\text { SYNC }} / \mathrm{DB} 5$

## $\overline{\mathrm{UNI}} / \mathrm{DB} 2$

CAL/DB1

## STBY/DB0

DVAL/ $\overline{S Y N C}$

Serial Data Output. Output serial data becomes active after $\overline{\mathrm{RFS}}$ goes low. Sixteen bits of data are clocked out starting with the MSB. Serial data is clocked out on the rising edge of SCLK and is valid on the subsequent falling edge of SCLK.
Receive Frame Synchronization. Active low logic input. This is a logic input with $\overline{\mathrm{RFS}}$ provided externally as a strobe or framing pulse to access serial data from the output register. Alternatively, $\overline{\mathrm{RFS}}$ may be provided by connecting this input to $\overline{\mathrm{DRDY}}$ which is active high in the serial mode. When $\overline{\mathrm{RFS}}$ is high, SDATA is high impedance.
Serial Clock. Logic Input. This input serial clock can be a continuous clock or, alternatively, it can be a non-continuous clock with the information being read from the AD7721 in smaller batches of data.
Serial Clock. Logic Output. The internal digital clock is provided as an output on this pin. This buffered signal can alternatively be used as the clock input to SCLK in the serial mode.
Single-Ended Analog Input, Digital Input. The AD7721 can accept a single-ended analog input. A logic high on the logic input SINGIP causes the pin VIN2 to be connected to the reference internally, enabling the AD7721 to accept a single-ended analog input. When SINGIP is at a logic low, the AD7721 operates with a differential input.
Synchronization Input. The internal digital filter is reset on the rising edge of a $\overline{\text { SYNC }}$ pulse. The filter reset operation requires 2048 clock cycles, throughout which $\overline{\text { DRDY }}$ remains low. Should a $\overline{\text { SYNC }}$ be requested while the part is in calibration mode, the SYNC will be acted upon immediately and the calibration will be abandoned.
Analog Input Range Select, Digital Input. The analog input range can be $\pm 1.25 \mathrm{~V}$ or 0 V to 2.5 V . The UNI pin is used to select the input range required. A logic high on this pin selects the $\pm 1.25 \mathrm{~V}$ range while a logic low selects the 0 V to 2.5 V analog input range.
Calibration Mode Pin. When this pir is pulsed high, the part is placed in its calibration mode and both the gain and offset are calibrated. At the end of calibration, new offset and gain calibration coefficients are loaded to the calibration registers.
Standby Mode Input. Logic input used to put the device into the power save (standby) mode. The STBY pin is low for normal operation and high for standby operation. When the part is placed in the standby mode, the values in the offset and gain registers are unaffected.
Data Valid Digital Output. An excessive overload on the modulator inputs can cause the modulator to go unstable. Once this condition is detected by internal circuits, the modulator is reset into a stable state and DVAL goes low for 2048 clock cycles. This period allows sufficient time for the modulator and digital filter to settle. An overload on the input pins can also cause clipping in the digital filter. This will cause DVAL to remain low. As well as the AD7721 indicating an overload by taking DVAL low, the AD7721 also highlights an overload by loading the output register. A positive overload causes the output register to be reset to $111 \ldots 11$ (unipolar input) or $011 \ldots 11$ (bipolar input). A negative overload causes the output register to be set to $000 \ldots 00$ (unipolar input) or $100 \ldots 00$ (bipolar input). When DVAL goes low, data can still be read from the interface and $\overline{\mathrm{DRDY}}$ will continue to indicate that there is data to be read.

## PARALLEL MODE ONLY

## DVAL/ $\overline{S Y N C}$

Data Valid Digital Output/Synchronization Input depending on the status of bit DB3 in the control register. When the AD7721 is powered up, bit DB3 will be set to " 0 ," causing this pin to be programmed as DVAL. The pin can be placed in SYNC mode by writing a " 1 " to bit DB3 in the control register. When changing the function of this pin from $\overline{\mathrm{SYNC}}$ mode to DVAL mode, a logic high must be applied to the pin.
DVAL: An overload in the modulator is highlighted as in the serial mode.

SDATA/DB11- Data Outputs DB11 to DB0, DB11 being the Most Significant Bit (MSB).

## AD7721

## SERIAL INTERFACE

The AD7721's serial communications port provides a flexible arrangement to allow easy interfacing to industry-standard microprocessors, microcontrollers and digital signal processors. The AD7721 can be operated in External-Clocking mode. This External-Clocking mode is designed for direct interface to systems that provide a serial clock output which is synchronized to the serial data output including microcontrollers such as the $80 \mathrm{C} 51,87 \mathrm{C} 51,68 \mathrm{HC} 11$ and 68 HC 05 and most digital signal processors. This external clock can have a frequency up to 20 MHz . Alternatively, the SCLK input can be provided by the master clock by connecting CLKOUT to SCLK. The RFS signal can also be provided by the AD7721 by connecting RFS to $\overline{\text { DRDY. }}$

Figure 2 shows the timing diagram for reading from the AD7721. $\overline{\mathrm{DRDY}}$ goes high to indicate the presence of a new word in the output register. $\overline{\text { DRDY }}$ remains high for one internal clock ( 15 MHz ) cycle. $\overline{\mathrm{RFS}}$ is taken low to access data from the AD7721. The serial clock input does not have to be continuous. The serial data can be accessed in a number of bytes. However, RFS must remain low for the duration of the data transfer operation. Although the AD7721 has a 12-bit digital output in the parallel mode, sixteen bits of data are available for transmission in the serial mode, starting with the MSB. Serial data is clocked out of the device on the rising edge of SCLK and is valid on the falling edge of SCLK. $\overline{\text { DRDY }}$ rises for one internal clock cycle when a new word is available in the output register. Any earlier result still in the output register is lost at this

## PARALLEL INTERFACE

## Read Operation.

The device defaults to parallel mode if $\overline{\mathrm{CS}}, \overline{\mathrm{RD}}$ and $\overline{\mathrm{WR}}$ are not tied to DGND together. Figure 3 shows a timing diagram for reading from the AD7721 in the parallel mode. When conversion is complete, $\overline{\mathrm{DRDY}}$ goes low to indicate that new data is available in the AD7721's output register. When the data has been read from the register using the $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ inputs, the $\overline{\mathrm{DRDY}}$ pin returns high. This $\overline{\mathrm{DRDY}}$ pin can be used to drive an edge-triggered interrupt of a microprocessor. $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ going low accesses the 12-bit conversion result.

## Write Operation

The write operation is used for self-calibration, selecting unipolar or bipolar analog input ranges, placing the part in power down mode (standby) or programming the function of pin DVAL/SYNC. When the AD7721 is placed in the write mode, data bits DB0 to DB3 and DB6 function as control bits, DB0 becoming the Standby mode bit, DB1 becoming the Calibration mode bit, DB2 being used to select the analog input range and, DB3 being used to select the function of pin DVAL/SYNC. Writing a logic " 1 " to DB2 selects bipolar operation while a logic low selects unipolar operation. For a single-ended input in bipolar mode, DB6 (SINGIP) is taken to a logic high. When SINGIP is at a logic low, VIN2 must be provided externally. The part powers up in unipolar mode. Calibration is performed by writing a logic " 1 " to DB1 while the part is put into the standby mode by inputting a logic high to DB0. Writing a "1" to bit DB3 places pin DVAL/SYNC in SYNC mode while time.


Figure 2. Serial Mode Output Register Read


Figure 3. Parallel Mode Output Register Read
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writing a " 0 " places the pin in DVAL mode. $\overline{\mathrm{CS}}$ and $\overline{\mathrm{WR}}$ going low places this information in the control register. Figure 4 shows a timing diagram for the write operation. Bits DB4 to DB5 and bits DB7 to DB15 are used to test the AD7721 in parallel mode. Thus, for normal operation, a logic " 0 " is inputted to these bits.


Figure 4. Write Timing Diagram

| READ | DB11 | DB10 | DB9 | DB8 | DB7 | DB6 | DB5 | DB4 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| WRITE | 0 | 0 | 0 | 0 | 0 | SINGIP | 0 | 0 |


| READ | DB3 | DB2 | DBI | DB0 |
| :--- | :--- | :--- | :--- | :--- |
| WRITE | DVAL/ $\overline{\text { SYNC }}$ | $\overline{\text { UNN }}$ | $\mathrm{CAL}^{2}$ | STBY |

## Figure 5, Control Register

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## ANALOG INPUT

In the bipolar mode configuration, the analog input range is $\pm 1.25 \mathrm{~V}$. The designed code transitions occur midway between successive integer LSB values. The output code is 2 s complement binary with $1 \mathrm{LSB}=0.61 \mathrm{mV}$ in parallel mode and $38 \mu \mathrm{~V}$ in serial mode. The ideal input/output transfer function is illustrated in Figure 6.


DIFFERENTIAL INPUT VOLTAGE (VIN1-VIN2)
Figure 6. Bipolar Mode Transfer Function

In the unipolar mode, the analog input range is 0 V to 2.5 V . Again, the designed code transitions occur midway between successive integer LSB values. The output code is straight binary with $1 \mathrm{LSB}=0.61 \mathrm{mV}$ in parallel mode and $38 \mu \mathrm{~V}$ in serial mode. The ideal input/output transfer function is shown in Figure 7.


Figute 7. Unipolar Mode Transfer Function

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FEATURES
Fast Conversion Time: 660 ns max 100 kHz Track-and-Hold Function 1 MHz Sample Rate Unipolar and Bipolar Input Ranges Ratiometric Reference Inputs No External Clock
Extended Temperature Range Operation Skinny 20-Pin DIPs, SOIC and 20-Terminal Surface Mount Packages

FUNCTIONAL BLOCK DIAGRAM

## PRODUCT HIGHLIGHTS

1. Fast Conversion Time

The half-flash conversion technique, coupled with fabrication on Analog Devices' LC ${ }^{2}$ MOS process, enables a very fast conversion time. The conversion time for the WR-RD mode is 660 ns , with 700 ns for the RD mode.
2. Built-In Track-and-Hold

This allows input signals with slew rates up to $1.6 \mathrm{~V} / \mu \mathrm{s}$ to be converted to 8 -bits without an external track-and-hold. This corresponds to a 5 V peak-to-peak, 100 kHz sine-wave signal.
3. Total Unadjusted Error

The AD7821 features an excellent total unadjusted error figure of less than $\pm 1$ LSB over the full operating temperature range.
4. Unipolar/Bipolar Input Ranges

The AD7821 is specified for single supply ( +5 V ) operation with a unipolar full-scale range of 0 to +5 V , and for dual supply ( $\pm 5 \mathrm{~V}$ ) operation with a bipolar input range of $\pm 2.5 \mathrm{~V}$. Typical performance characteristics are given for other input ranges.
5. Dynamic Specifications for DSP Users In addition to the traditional ADC specifications, the AD7821 is specified for ac parameters, including signal-tonoise ratio, distortion and slew rate.


## GENERAL DESCRIPTION

The AD7821 is a high-speed, 8 -bit, sampling, analog-to-digital converter that offers improved performance over the popular AD7820. It offers a conversion time of 660 ns (vs. $1.36 \mu \mathrm{~s}$ for the AD7820) and 100 kHz signal bandwidth (vs. 6.4 kHz ). The sampling instant is better defined and occurs on the falling edge of $\overline{\mathrm{WR}}$ or $\overline{\mathrm{RD}}$. The provision of a $\mathrm{V}_{\mathrm{SS}}$ pin (Pin 19) allows the part to operate from $\pm 5 \mathrm{~V}$ supplies and to digitize bipolar input signals. Alternatively, for unipolar inputs, the $\mathrm{V}_{\mathrm{Ss}}$ pin can be grounded and the AD7821 will operate from a single +5 V supply, like the AD7820.
The AD7821 has a built-in track-and-hold function capable of digitizing full-scale signals up to 100 kHz max. It also uses a half-flash conversion technique that eliminates the need to generate a CLK signal for the ADC.
The AD7821 is designed with standard microprocessor control signals ( $\overline{\mathrm{CS}}, \overline{\mathrm{RD}}, \overline{\mathrm{WR}}, \mathrm{RDY}, \overline{\mathrm{INT}}$ ) and latched, three-state data outputs capable of interfacing to high-speed data buses. An overflow output ( $\overline{\mathrm{OFL}})$ is also provided for cascading devices to achieve higher resolution.

The AD7821 is fabricated in Linear-Compatible CMOS (LC ${ }^{2}$ MOS), an advanced, mixed technology process combining precision bipolar circuits with low-power CMOS logic. The part features a low power dissipation of 50 mW .

AD7821-SPEC|FICATIONS $\begin{aligned} & V_{D D}=+5 V \pm 5 \%, \text { GND }=0 \text { V. Unipolar Input Range: } V_{S S}=G N D, V_{\text {REE }}(+)= \\ & 5 V V_{\text {REF }}(-)=G N D \text {. Bipolar Input Range: } V_{S S}=-5 \mathrm{~V} \pm 5 \%, V_{\text {REF }}(+)=2.5 \mathrm{~V}\end{aligned}$ $\mathbf{V}_{\text {REF }}(-)=-2.5 \mathrm{~V}$. These test conditions apply unless otherwise stated. All specifications $\mathrm{I}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ unless otherwise stated. Specifications apply for RD Mode (Pin $7=\mathbf{0}$ V).

| Parameter | K Version ${ }^{1}$ | B, T Versions | Units | Comments |
| :---: | :---: | :---: | :---: | :---: |
| UNIPOLAR INPUT RANGE <br> Resolution ${ }^{2}$ <br> Total Unadjusted Error ${ }^{3}$ <br> Minimum Resolution for which <br> No Missing Codes are Guaranteed | $\begin{aligned} & 8 \\ & \pm 1 \\ & 8 \end{aligned}$ | $\begin{aligned} & 8 \\ & \pm 1 \\ & 8 \end{aligned}$ | Bits <br> LSB max <br> Bits |  |
| BIPOLAR INPUT RANGE <br> Resolution ${ }^{2}$ <br> Zero Code Error <br> Full Scale Error <br> Signal-to-Noise Ratio (SNR) ${ }^{3}$ <br> Total Harmonic Distortion (THD) ${ }^{3}$ <br> Peak Harmonic or Spurious Noise ${ }^{3}$ Intermodulation Distortion (IMD) ${ }^{3}$ <br> Slew Rate, Tracking ${ }^{3}$ | $\begin{aligned} & 8 \\ & \pm 1 \\ & \pm 1 \\ & 45 \\ & -50 \\ & -50 \\ & \\ & -50 \\ & -50 \\ & 1.6 \\ & 2.36 \end{aligned}$ | $\begin{aligned} & 8 \\ & \pm 1 \\ & \pm 1 \\ & 45 \\ & -50 \\ & -50 \\ & \\ & -50 \\ & -50 \\ & 1.6 \\ & 2.36 \end{aligned}$ | Bits <br> LSB max <br> LSB max <br> dB min <br> dB max <br> dB max <br> dB max <br> dB max <br> $\mathrm{V} / \mu \mathrm{s} \max$ <br> V/ $\mu \mathrm{s}$ typ | $\mathrm{V}_{\mathrm{IN}}=99.85 \mathrm{kHz}$ Full-Scale Sine Wave with $\mathrm{f}_{\text {SAMPLING }}=500 \mathrm{kHz}$ <br> $\mathrm{V}_{\text {IN }}=99.85 \mathrm{kHz}$ Full-Scale Sine Wave with $\mathrm{f}_{\text {SAMPLING }}=500 \mathrm{kHz}$ <br> $\mathrm{V}_{\mathrm{IN}}=99.85 \mathrm{kHz}$ Full-Scale Sine Wave with $\mathrm{f}_{\text {SAMPLING }}=500 \mathrm{kHz}$ <br> $\mathrm{fa}(84.72 \mathrm{kHz})$ and $\mathrm{fb}(94.97 \mathrm{kHz})$ Full-Scale <br> Sine Waves with $\mathrm{f}_{\text {SAMPLING }}=500 \mathrm{kHz}$ <br> Second Order Terms <br> Third Order Terms |
| REFERENCE INPUT <br> Input Resistance <br> $\mathrm{V}_{\text {REF }}(+$ ) Input Voltage Range <br> $\mathrm{V}_{\text {REF }}(-)$ Input Voltage Range | $\begin{aligned} & 1.0 / 4.0 \\ & \mathrm{~V}_{\mathrm{REF}}(-) / \mathrm{V}_{\mathrm{DD}} \\ & \mathrm{~V}_{\mathrm{SS}} / \mathrm{V}_{\mathrm{REF}}(+) \end{aligned}$ | $\begin{aligned} & 1.0 / 4.0 \\ & \mathrm{~V}_{\mathrm{REF}}(-) / \mathrm{V}_{\mathrm{DD}} \\ & \mathrm{~V}_{\mathrm{SS}} / \mathrm{V}_{\mathrm{REF}}(+) \end{aligned}$ | $\mathrm{k} \Omega \min / \mathrm{k} \Omega$ max <br> $\mathrm{V} \min / \mathrm{V}$ max <br> $\mathrm{V} \min / \mathrm{V} \max$ |  |
| ANALOG INPUT <br> Input Voltage Range Input Leakage Current Input Capacitance | $\begin{aligned} & \mathrm{V}_{\mathrm{REF}}(-) / \mathrm{V}_{\mathrm{REF}}(+) \\ & \pm 3 \\ & 55 \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\text {REF }}(-) / \mathrm{V}_{\text {REF }}(+) \\ & \pm 3 \\ & 55 \end{aligned}$ | $\mathrm{V} \min / V \max$ <br> $\mu \mathrm{A}$ max <br> pF typ | $-5 \mathrm{~V} \leq \mathrm{V}_{\text {IN }} \leq+5 \mathrm{~V}$ |
| LOGIC INPUTS <br> $\overline{\mathrm{CS}}, \overline{\mathrm{WR}}, \overline{\mathrm{RD}}$ <br> $\mathrm{V}_{\text {INH }}$ <br> $V_{\text {INL }}$ <br> $\mathrm{I}_{\mathrm{INH}}(\overline{\mathrm{CS}}, \overline{\mathrm{RD}})$ <br> $\mathrm{I}_{\mathrm{INH}}(\overline{\mathrm{WR}})$ <br> $\mathrm{I}_{\text {INL }}$ <br> Input Capacitance ${ }^{4}$ <br> MODE <br> $\mathrm{V}_{\text {INH }}$ <br> $\mathrm{V}_{\text {INL }}$ <br> $\mathrm{I}_{\text {INH }}$ <br> $\mathrm{I}_{\mathrm{INL}}$ <br> Input Capacitance ${ }^{4}$ | $\begin{aligned} & 2.4 \\ & 0.8 \\ & 1 \\ & 3 \\ & -1 \\ & 8 \end{aligned}$ <br> 3.5 <br> 1.5 <br> 200 <br> $-1$ <br> 8 | $\begin{aligned} & 2.4 \\ & 0.8 \\ & 1 \\ & 3 \\ & -1 \\ & 8 \\ & 3.5 \\ & 1.5 \\ & 200 \\ & -1 \\ & 8 \\ & \hline \end{aligned}$ | V min <br> V max <br> $\mu \mathrm{A}$ max <br> $\mu \mathrm{A}$ max <br> $\mu \mathrm{A}$ max <br> pF max <br> $V$ min <br> V max <br> $\mu \mathrm{A}$ max <br> $\mu \mathrm{A}$ max <br> pF max | Typically 5 pF <br> $50 \mu \mathrm{~A}$ typ <br> Typically 5 pF |
| ```LOGIC OUTPUTS DB0-DB7, \overline{OFL, \overline{INT}}\mathbf{}\mathrm{ 位} V VOL I OUTT (DB0-DB7) Output Capacitance (DB0-DB7) RDY VOL IOUT Output Capacitance4``` | $\begin{aligned} & 4.0 \\ & 0.4 \\ & \pm 3 \\ & 8 \\ & 0.4 \\ & \pm 3 \\ & 8 \end{aligned}$ | $\begin{aligned} & 4.0 \\ & 0.4 \\ & \pm 3 \\ & 8 \\ & \\ & 0.4 \\ & \pm 3 \\ & 8 \end{aligned}$ | V min <br> V max <br> $\mu \mathrm{A}$ max <br> pF max <br> V max <br> $\mu \mathrm{A}$ max <br> pF max | $I_{\text {SOURCE }}=360 \mu \mathrm{~A}$ <br> $\mathrm{I}_{\text {SINK }}=1.6 \mathrm{~mA}$ <br> Floating State Leakage <br> Typically 5 pF $\mathrm{I}_{\mathrm{SINK}}=2.6 \mathrm{~mA}$ <br> Floating State Leakage <br> Typically 5 pF |
| POWER SUPPLY <br> $I_{D D}$ <br> Iss <br> Power Dissipation <br> Power Supply Sensitivity | $\begin{aligned} & 15 \\ & 100 \\ & 50 \\ & \pm 1 / 4 \end{aligned}$ | $\begin{aligned} & 20 \\ & 100 \\ & 50 \\ & \pm 1 / 4 \end{aligned}$ | mA max $\mu \mathrm{A}$ max mW typ LSB max | $\begin{aligned} & \overline{\mathrm{CS}}=\overline{\mathrm{RD}}=0 \mathrm{~V} \\ & \overline{\mathrm{CS}}=\overline{\mathrm{RD}}=0 \mathrm{~V} \\ & \pm 1 / 16 \mathrm{LSB} \text { typ, } \mathrm{V}_{\mathrm{DD}}=4.75 \mathrm{~V} \text { to } 5.25 \mathrm{~V}, \\ & \left(\mathrm{~V}_{\mathrm{REF}}(+)=4.75 \mathrm{~V} \text { max for Unipolar Mode }\right) \end{aligned}$ |

## NOTES

${ }^{1}$ Temperature Ranges are as follows: K Version $=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; B Version $=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; T Version $=-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
${ }^{2} 1 \mathrm{LSB}=19.53 \mathrm{mV}$ for both the unipolar $(0$ to $+5 \mathrm{~V})$ and bipolar $(-2.5 \mathrm{~V}$ to $+2.5 \mathrm{~V})$ input ranges.
${ }^{3}$ See Terminology.
${ }^{4}$ Sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance.
Specifications subject to change without notice.

TIMING CHARACTERISTICS ${ }^{1}$

$$
\left(V_{D D}=+5 V \pm 5 \%, V_{S S}=0 V \text { or }-5 V \pm 5 \% \text {; Unipolar or Bipolar Input Range }\right)
$$



NOTES
${ }^{1}$ Sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance. All input control signals are specified with $\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of $+5 \mathrm{~V})$ and timed from a voltage level of 1.6 V .
${ }^{2} \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$.
${ }^{3}$ Measured with load circuits of Figure 1 and defined as the time required for an output to cross 0.8 V or 2.4 V .
${ }^{4}$ Defined as the time required for the data lines to change 0.5 V when loaded with the circuits of Figure 2.
Specifications subject to change without notice.

## Test Circuits



Figure 1. Load Circuits for Data Access Time Test

a. $V_{O H}$ to High Z
b. $V_{O L}$ to High $Z$

## ORDERING GUIDE

| Model $^{\mathbf{1}}$ | Temperature <br> Range | Total Unadjusted <br> Error (LSB) | Package <br> Option $^{2}$ |
| :--- | :--- | :--- | :--- |
| AD7821KN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1$ max | $\mathrm{N}-20$ |
| AD7821KP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1$ max | $\mathrm{P}-20 \mathrm{~A}$ |
| AD7821KR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1 \max$ | $\mathrm{R}-20$ |
| AD7821BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1 \max$ | $\mathrm{Q}-20$ |
| AD7821TQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\pm 1 \max$ | $\mathrm{Q}-20$ |
| AD7821TE | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\pm 1 \max$ | $\mathrm{E}-20 \mathrm{~A}$ |

## NOTES

${ }^{1}$ To order MIL-STD-883, Class B processed parts, add /883B to part number. Contact local sales office for military data sheet.
${ }^{2} \mathrm{E}=$ Leadless Ceramic Chip Carrier; $\mathrm{N}=$ Plastic DIP; $\mathrm{P}=$ Plastic Leaded Chip Carrier; $\mathrm{Q}=$ Cerdip; $\mathrm{R}=$ SOIC. For outline information see Package Information section.

Figure 2. Load Circuits for Data Hold Time Test

## ABSOLUTE MAXIMUM RATINGS*

| $\mathrm{V}_{\text {DD }}$ to GI | +7V |
| :---: | :---: |
| $\mathrm{V}_{\text {Ss }}$ to GND. | $+0.3 \mathrm{~V}, 7 \mathrm{~V}$ |
| Digital Input Voltage to GND (Pins 6-8, 13). | $-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| Digital Output Voltage to GND (Pins 2-5, 9, 14-18). | $-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| $\mathrm{V}_{\text {REF }}(+)$ to GND | $\mathrm{V}_{\text {ss }}-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| $\mathrm{V}_{\text {REF }}(-)$ to GND. | $. \mathrm{V}_{\text {Ss }}-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| $\mathrm{V}_{\text {IN }}$ to GND. . . | . $\mathrm{V}_{\text {ss }}-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| Operating Temperature Range |  |
| Commercial (K Version) | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |

Industrial (B Version). . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Extended (T Version) . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10secs) . . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Power Dissipation (Any Package) to $+75^{\circ} \mathrm{C}$. . . . . . . 450 mW
Derates above $+75^{\circ} \mathrm{C}$ by . . . . . . . . . . . . . . . . . . . . $6 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are inserted.


PIN CONFIGURATIONS


## PIN FUNCTION DESCRIPTION

| Pin | Mnemonic | Description |
| :---: | :---: | :---: |
| 1 | $\mathrm{V}_{\text {IN }}$ | Analog Input: Range $\mathrm{V}_{\mathrm{REF}}(-) \leq \mathrm{V}_{\mathrm{IN}} \leq$ $\mathrm{V}_{\mathrm{REF}}{ }^{(+)}$. |
| 2 | DB0 | Three-State Data Output (LSB). |
| 3-5 | DB1-DB3 | Three-State Data Outputs. |
| 6 | $\overline{\text { WR/RDY }}$ | WRITE control input/READY status output. See Digital Interface section. |
| 7 | MODE | Mode Selection Input. It determines whether the device operates in the WR-RD or RD mode. This input is internally pulled low through a $50 \mu \mathrm{~A}$ current source. See Digital Interface section. |
| 8 | $\overline{\mathbf{R D}}$ | READ Input. $\overline{R D}$ must be low to access data from the part. See Digital Interface section. |
| 9 | $\overline{\text { INT }}$ | INTERRUPT Output. $\overline{\text { INT }}$ going low indicates that the conversion is complete. $\overline{\text { INT }}$ returns high on the rising edge of $\overline{\mathrm{CS}}$ or $\overline{\mathrm{RD}}$. See Digital Interface section. |
| 10 | GND | Ground. |
| 11 | $\mathrm{V}_{\mathrm{REF}}(-)$ | Lower limit of reference span. <br> Range: $\mathbf{V}_{\mathbf{S S}} \leq \mathrm{V}_{\mathbf{R E F}}(-)<\mathrm{V}_{\mathbf{R E F}}(+)$. |
| 12 | $\mathbf{V}_{\mathbf{R E F}}{ }^{(+)}$ | Upper limit of reference span. <br> Range: $\mathbf{V}_{\mathbf{R E F}}(-)<\mathrm{V}_{\mathbf{R E F}}(+) \leq \mathrm{V}_{\mathbf{D D}}$. |

# 3 V to 5 V Single Supply, 200 kSPS, Single/Multichannel 12-Bit Sampling ADCs 

## FEATURES

Battery-Compatible Supply Voltage: Guaranteed
Specs for $V_{D D}$ of 3 V to 5.5 V
AD7853/AD7858: 200 kSPS, AD7853L/AD7858L: 100 kSPS
Pseudo-Differential Input with Two Input Ranges (AD7853)
8 Single Ended or 4 Pseudo-Differential Inputs (AD7858) Self and System Calibration
Read/Write Capability of Calibration Data Low Power

AD7853/AD7858: $15 \mathrm{~mW}\left(\mathrm{~V}_{\mathrm{DD}}=3 \mathrm{~V}\right)$
AD7853L/AD7858L: $5.5 \mathrm{~mW}\left(\mathrm{~V}_{\mathrm{DD}}=3 \mathrm{~V}\right)$
Power-Down Mode: $25 \mu$ W Power Consumption
Flexible Serial Interface
Three-Wire SPI Compatible
Two-Wire 8051 Compatible
24-Pin DIP, SOIC and SSOP Packages

## APPLICATIONS

Battery-Powered Systems (Portable PCs, Personal Digital Assistants (PDAs))

## Pen Computers

Instrumentation and Control Systems
High Speed Modems

## GENERAL DESCRIPTION

The AD7853/AD7858 are high speed, low power, 12-bit ADCs that operate from a single 3 V or 5 V power supply, the AD7853 being the single channel version and the AD7858 the multichannel version. The ADCs contain self-calibration and system calibration options to ensure accurate operation over time and temperature.
The AD7853/AD7858 is capable of 200 kHz throughput rate. The input track-and-hold acquires a signal in 500 ns and features a pseudo-differential sampling scheme. The AD7853 has the added advantage of two input voltage ranges ( 0 V to $\mathrm{V}_{\mathrm{REF}}$ and $-\mathrm{V}_{\mathrm{REF}} / 2$ to $+\mathrm{V}_{\mathrm{REF}} / 2$ ). Input signal range is to the supply and the part is capable of converting full power signals to 100 kHz .

CMOS construction ensures low power dissipation ( 18 mW typ) with power-down mode ( $25 \mu \mathrm{~W}$ typ). The part is available in 24 -pin, 0.3 inch-wide DIP, 24-lead SOIC and 24-lead SSOP packages.

## PRODUCT HIGHLIGHTS

1. Operation with either 3 V or 5 V power supplies.
2. Operates with reference voltages from 1.2 V to the supply.
3. Unipolar analog input range from 0 V to $\mathrm{V}_{\text {SUPPLY }}$.
4. Self and System calibration including power-down mode.

## FUNCTIONAL BLOCK DIAGRAMS


5. Versatile serial I/O port.
6. Single channel (AD7853) or 8 channel (AD7858).

[^42] complete data sheet, call our fax retrieval system at 1-800-446-6212.
This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

AD7853/AD7858-5 V SPECIFICATIONS ${ }^{1,2}$ 200 kHz (AD7853/AD7858) 100 kHz (AD7853L/AD7858L); $\overline{\text { SLEEP }}=$ Logic High; $T_{A}=T_{\text {miN }}$ to $T_{\text {max }}$, unless otherwise noted.)

| Parameter | A Version ${ }^{1}$ | $B$ Version ${ }^{1}$ | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: |
| DYNAMIC PERFORMANCE Signal-to-Noise Ratio ${ }^{3}$ (SNR) | 70 | 71 | dB min | Typically SNR Is 72 dB <br> $\mathrm{V}_{\mathrm{IN}}=10 \mathrm{kHz}$ Sine Wave, $\mathrm{f}_{\text {SAMPLE }}=200 \mathrm{kHz}(100 \mathrm{kHz})^{4}$ |
| Total Harmonic Distortion (THD) | -78 | -80 | dB max | $\mathrm{V}_{\text {IN }}=10 \mathrm{kHz}$ Sine Wave, $\mathrm{f}_{\text {SAMPLE }}=200 \mathrm{kHz}(100 \mathrm{kHz})^{4}$ |
| Peak Harmonic or Spurious Noise | -78 | -80 | dB max | $\mathrm{V}_{\text {IN }}=10 \mathrm{kHz}, \mathrm{f}_{\text {SAMPLE }}=200 \mathrm{kHz}(100 \mathrm{kHz})^{4}$ |
| Intermodulation Distortion (IMD) |  |  |  |  |
| Second Order Terms | -78 | -80 | dB typ | . $\mathrm{fa}=9.983 \mathrm{kHz}, \mathrm{fb}=10.05 \mathrm{kHz}, \mathrm{f}_{\text {SAMPLE }}=200 \mathrm{kHz}(100 \mathrm{kHz})^{4}$ |
| Third Order Terms | -78 | -80 | dB typ | $\mathrm{fa}=9.983 \mathrm{kHz}, \mathrm{fb}=10.05 \mathrm{kHz}, \mathrm{f}_{\text {SAMPLE }}=200 \mathrm{kHz}(100 \mathrm{kHz})^{4}$ |
| Channel-to-Channel Isolation | -80 | -80 | dB max | (AD7858 Only) |
| DC ACCURACY |  |  |  | (Any Channel AD7858 Only) |
| Resolution | 12 | 12 | Bits |  |
| Integral Nonlinearity | $\pm 1$ | $\pm 0.5$ | LSB max |  |
| Differential Nonlinearity | $\pm 1$ | $\pm 0.5$ | LSB max | Guaranteed No Missed Codes to 12 Bits |
| Unipolar Offset Error | $\pm 1$ | $\pm 0.5$ | LSB max |  |
| Unipolar Offset Error Match | 2 | 2 | LSB max | (AD7858 Only) |
| Positive Full-Scale Error | $\pm 2$ | $\pm 1$ | LSB max | A \% . |
| Negative Full-Scale Error | $\pm 2$ | $\pm 1$ | LSB max |  |
| Full-Scale Error Match ${ }^{5}$ | 2 | 2 | LSB max | (AD7858 Only) |
| Bipolar Zero Error | $\pm 1$ | $\pm 0.5$ | LSB max |  |
| Bipolar Zero Error Match | 2 | 2 | LSB max | (AD7858 Only) |
| ANALOG INPUT |  |  |  |  |
| Input Voltage Ranges (AD7853/AD7858) | 0 to $\mathrm{V}_{\text {ref }}$ | 0 to $\mathrm{V}_{\text {ReF }}$ | Volts | i.e., $\operatorname{AIN}(+)-\operatorname{AIN}(-)=0 \mathrm{~V}$ to $\mathrm{V}_{\text {REF }}$ |
| (AD7853 Only) | $\pm \mathrm{V}_{\mathrm{REF}} / 2$ | $\pm \mathrm{V}_{\mathrm{REF}} / 2$ | Volts | i.e., $\operatorname{AIN}(+)-\operatorname{AIN}(-)=-\mathrm{V}_{\text {REF }} / 2$ to $+\mathrm{V}_{\text {REF }} / 2$ |
| Leakage Current | $\pm 1$ | $\pm 1$ | $\mu \mathrm{A}$ max | - |
| Input Capacitance | 20 | 20 | pF typ |  |
| REFERENCE INPUT/OUTPUT |  |  |  | - |
| $\mathrm{REF}_{\text {IN }}$ Input Voltage Range | 2.3/V $\mathrm{V}_{\mathrm{DD}}$ | $2.3 / V_{\text {DD }}$ | $V$ min/max | Functional from 1.2 V |
| Input Impedance |  |  | $\mathrm{k} \Omega$ min | Resistor Connected to Internal Reference Node |
| REF ${ }_{\text {out }}$ Output Voltage | 2:3/2.7 | 2.3/2.7 | $\checkmark$ min/max |  |
| $\mathrm{REF}_{\text {Out }}$ Tempco | 40 | 40 | ppm $/ 0 \mathrm{C}$ typ |  |
| LOGIC INPUTS |  |  | cte |  |
| Input High Voltage, $\mathrm{V}_{\text {INH }}$ | 2.4 | 2.4 | $V$ min |  |
| Input Low Voltage, $\mathrm{V}_{\text {INL }}$ | 0.8 | 0.8 | V max |  |
| Input Current, $\mathrm{I}_{\mathrm{IN}}$ | $\pm 10$ | $\pm 10$ | $\mu \mathrm{A}$ max | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{DD}}$ |
| Input Capacitance, $\mathrm{C}_{\text {IN }}{ }^{6}$ | 10 | 10 | pF max |  |
| LOGIC OUTPUTS |  |  |  |  |
| Output High Voltage, $\mathrm{V}_{\mathrm{OH}}$ | 4 | 4 | V min | $\mathrm{I}_{\text {SOURCE }}=200 \mu \mathrm{~A}$ |
| Output Low Voltage, VoL | 0.4 | 0.4 | V max | $\mathrm{I}_{\text {SINK }}=0.8 \mathrm{~mA}$ |
| Floating-State Leakage Current | $\pm 10$ | $\pm 10$ | $\mu \mathrm{A}$ max |  |
| Floating-State Output Capacitance ${ }^{6}$ | 10 | 10 | pF max |  |
| Output Coding (AD7853/AD7858) (AD7853 Only) | Straight (Natural) Binary 2s Complement |  |  | Unipolar Input Range Bipolar Input Range |
| CONVERSION RATE |  |  |  |  |
| Conversion Time | $4.5(9)^{4}$ | 4.5 (9) ${ }^{4}$ | $\mu \mathrm{s}$ max | (L Versions Only) |
| Track/Hold Acquisition Time | $0.5(1)^{4}$ | $0.5(1)^{4}$ | $\mu \mathrm{s}$ max | (L Versions Only) |
| POWER REQUIREMENTS |  |  |  |  |
| $\mathrm{AV}_{\mathrm{DD}}, \mathrm{DV}_{\mathrm{DD}}$ | +4.5/+5.5 | +4.5/+5.5 | V min/max |  |
| $\mathrm{I}_{\mathrm{DD}}$ | $5.5(1.8)^{4}$ | $5.5(1.8)^{4}$ | mA max | Typically $4.5 \mathrm{~mA}(1.5)^{4} ; \overline{\text { SLEEP }}=\mathrm{V}_{\text {DD }}$ |
| Sleep Mode |  |  |  | Logic Inputs @ 0 V or $\mathrm{V}_{\text {DD }}$; $\overline{\text { SLEEP }}=0 \mathrm{~V}$ |
| With External Clock On | 100 | 100 | $\mu \mathrm{A}$ max | Typically $70 \mu \mathrm{~A}$. PMGT (Control Register) $=1$ |
|  | TBD | TBD | $\mu \mathrm{A}$ max | PMGT (Control Register) $=0$ |
| With External Clock Off | 10 | 10 | $\mu \mathrm{A}$ max | Typically $7 \mu \mathrm{~A}$. PMGT (Control Register) $=1$ |
|  | TBD | TBD | $\mu \mathrm{A}$ max | PMGT (Control Register) $=0$. |
| Normal Mode Power Dissipation | $30(10)^{4}$ | $30(10)^{4}$ | mW max | $\mathrm{V}_{\mathrm{DD}}=5.5 \mathrm{~V}$ : Typically $25 \mathrm{~mW}(8){ }^{4} ; \overline{\text { SLEEP }}=\mathrm{V}_{\mathrm{DD}}$ |
| Save Mode Power Dissipation |  |  |  |  |
| With External Clock On | 0.55 | 0.55 | mW max | $\mathrm{V}_{\mathrm{DD}}=5.5 \mathrm{~V}$ : Typically $0.4 \mathrm{~mW} ; \overline{\text { SLEEP }}=0 \mathrm{~V}$ |
| With External Clock Off | 55 | 55 | $\mu \mathrm{W}$ max | $\mathrm{V}_{\mathrm{DD}}=5.5 \mathrm{~V}$ : Typically $30 \mu \mathrm{~W} ; \overline{\text { SLEEP }}=0 \mathrm{~V}$ |

## NOTES

${ }^{1}$ Temperature ranges as follows: A, B Versions: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.
${ }^{2}$ Specifications apply after calibration.
${ }^{3}$ SNR calculation includes distortion and noise components.
${ }^{4}$ Specifications written within parentheses () refer to the AD7853L/AD7858L.
${ }^{5}$ Full-scale error match is the worst case of the positive full-scale error match or the negative full-scale error match.
${ }^{6}$ Sample tested @ $+25^{\circ} \mathrm{C}$ to ensure compliance.
Specifications subject to change without notice.
This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

## (AD7853/AD7858) 100 kHz (AD7853L/AD7858L); $\overline{\text { SLEEP }}=$ Logic High; $\mathrm{T}_{A}=\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {max }}$, unless otherwise noted.)



## NOTES

${ }^{1}$ Temperature ranges as follows: A, B Versions: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.
${ }^{2}$ Specifications apply after calibration.
${ }^{3}$ SNR calculation includes distortion and noise components.
${ }^{4}$ Specifications written within parentheses () refer to the AD7853L/AD7858L.
${ }^{5}$ Full-scale error match is the worst case of the positive full-scale error match or the negative full-scale error match.
${ }^{6}$ Sample tested @ $+25^{\circ} \mathrm{C}$ to ensure compliance.
Specifications subject to change without notice.
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| Parameter | Limit at $\mathrm{T}_{\text {MIN }}, \mathrm{T}_{\text {MAX }}$ (A, B, S Versions) | Units | Description |
| :---: | :---: | :---: | :---: |
| $\mathrm{f}_{\text {CLKIN }}$ | 500 | kHz min MHz max | Master Clock Frequency <br> ( 2 MHz for the AD7853L/AD7858L) |
| $\mathrm{f}_{\text {SCLK }}$ | $\mathrm{f}_{\text {CLK IN }}$ | MHz max | Serial Clock Input Frequency |
| $\mathrm{t}_{1}$ | $100^{3}$ | ns min | CONVST Pulse Width |
| $\mathrm{t}_{2}$ | 50 | ns max | $\overline{\text { CONVST }}$ to BUSY Propagation Delay |
| $\mathrm{t}_{\text {CONVERT }}$ | 4.5 ( $18 \times \mathrm{t}_{\text {CLKIN }}$ ) | $\mu \mathrm{s}$ max | Conversion Time |
| $\mathrm{t}_{3}$ | 60 (60/0.4 $\times \mathrm{t}_{\text {SCLK }}$ ) | $n \mathrm{~ns} \min (\min / \mathrm{max})$ | $\overline{\text { SYNC }}$ to SCLK falling Edge Setup Time (Continuous SCLK input). |
| $\mathrm{t}_{3}$ | 60 | ns min | $\overline{\text { SYNC }}$ to SCLK falling Edge Setup Time (AD7853 only). |
| $\mathrm{t}_{4}$ | $60^{4}$ | ns max | Delay from SYNC until DOUT 3-state disabled. |
| $\mathrm{t}_{4 \mathrm{~A}}$ | $70^{4}$ | ns max | Delay from SYNC until DIN 3-state disabled. |
| $\mathrm{t}_{5}$ | $60^{4}$ | ns max | Data Access time after falling edge of SCLK. |
| $\mathrm{t}_{6}$ | 40 | ns min | Data Setup Time Prior to rising edge of SCLK. |
| $\mathrm{t}_{7}$ | 0 | ns min | Data Valid to SCLK Hold Time. |
| $\mathrm{t}_{8}$ | $0.4 \times \mathrm{tsCLK}^{5}$ | ns min | SCLK High Pulse Width |
| $\mathrm{t}_{9}$ | $0.4 \times \mathrm{tsCLK}^{5}$ | ns min | SCLK Low Pulse Width |
| $\mathrm{t}_{10}$ | 30 (30/0.4 $\times \mathrm{t}_{\text {SCLK }}$ ) | $\mathrm{ns} \min (\min / \mathrm{max})$ | SCLK Rising Edge to SYNC Hold Time (Continuous SCLK). |
| $\mathrm{t}_{10 \mathrm{~A}}$ | 30 | ns min | SCLK Rising Edge to SYNC Hold Time (AD7853 only). |
| $\mathrm{t}_{11}$ | $60^{4}$ | ns max | Delay from SYNC until DOUT 3 -state enabled. |
| $\mathrm{t}_{11 \mathrm{~A}}$ | $70^{4}$ | ns max | Delay from SYNC until DIN 3-state enabled. |
| $\mathrm{t}_{12}$ | $80^{4}$ | ns max | Delay from SCLK to DIN being configured as output. |
| $\mathrm{t}_{13}$ | $60^{4}$ | ns max | Delay from SCLK to DIN being configured as input. |
| $\mathrm{t}_{14}$ | 100 | ns max | $\overline{\mathrm{CAL}}$ Rising Edge to BUSY delay. |
| $\mathrm{t}_{15}$ | 50 | ns max | CONVST to BUSY delay in calibration sequence. |
| $\mathrm{t}_{\text {CAL }}$ | $\mathrm{N}_{2} \times \mathrm{t}_{\text {CLKIN }}$ |  | ${ }^{*}$ Full self calibration time, $\mathrm{N}_{2}$ an integer. |
| $\mathrm{t}_{\text {CAL1 }}$ | $\mathrm{N}_{3} \times \mathrm{t}_{\text {CLKIN }}$ |  | Internal DAC plus system full-scale calibration time, $\mathrm{N}_{3}$ an integer. |
| ${ }^{\text {t CAL } 2}$ | $\mathrm{N}_{4} \times \mathrm{t}_{\text {CLKIN }}$ |  | System offset calibration time, $\mathrm{N}_{4}$ an integer. |

## NOTES

${ }^{1}$ Sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance. The timing figures here are for the AD7853/AD7858 only and not for the AD7853L/AD7858L, so the timing figures for the AD7853L/AD7858L will reflect that the AD7853L/AD7858L operates at half the speed of the AD7853, and an example of this is given with the max master clock frequency of 2.5 MHz for the AD7853L/AD7858L. All input signals are specified with $\operatorname{tr}=\mathrm{tf}=5 \mathrm{~ns}\left(10 \%\right.$ to $90 \%$ of $\left.\mathrm{V}_{\mathrm{DD}}\right)$ and timed from a voltage level of 1.6 V .
${ }^{2}$ See Table I and Figures $2,4,5,6,8$ where all the timing diagrams are for ADC output data as distinct from calibration or control register data in which case there would not be the 4 leading zeros with the output data. Instead there would be 4 data bits DB15-DB12 in their place.
${ }^{3}$ The CONVST pulse width will depend on the way the part is being operated. For operation where the BUSY is not connected to the SLEEP pin then the CONVST pulse width is 100 ns min as stated above. If BUSY is connected to the $\overline{\text { SLEEP }}$ pin so that the part goes into sleep mode after conversion the conversion time will be different and will also be dependent on the PMGT bit in the control register.
${ }^{4} \mathrm{t}_{4}$ is measured with the load circuit of Figure 1 and defined as the time required for the output to cross 0.8 V or 2.4 V .
${ }^{5}$ SCLK mark/space ratio (measured from a voltage level of 1.6 V ) is $40 / 60$ to $60 / 40$.


Figure 1. Load Circuit for Digital Output Timing Specifications

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## TYPICAL TIMING DIAGRAM

All the timing diagrams (Figures 2-9) are for ADC output data from the part, and this is why there are 4 leading zeros before the 12 bits of data. However for a control register or calibration register read, there will not be 4 leading zeros on the output data. These 4 leading zeros will be replaced by data bits DB15DB12 for this read operations.
In Figure 2 below we have a typical read and write timing diagram with the CONVST and BUSY. The essence of this is to show exactly what most of the timing numbers relate to. Here the reading from and writing to the part is shown after the conversion so in this case the maximum conversion rate cannot be achieved. To achieve the maximum throughput rate of 100 kHz (AD7853L) or 200 kHz (AD7853) the user must read from and write to the part during conversion.
There is a very useful mode of operation for reducing power consumption. In this power save mode of operation the BUSY can be connected to the SLEEP pin so that at the end of conversion the part automatically goes into sleep mode. However on the next $\overline{\text { CONVST }}$ pulse, the part then must be allowed a reasonable time to "wake up" before converting the signal on the AIN pin. Thus the CONVST pulse width must be made longer and will extend well beyond the rising edge of the BUSY (see specification for CONVST pulse width) so that it caters for what is called "wake-up" time.

ORDERING GUIDE

| Model | Linearity <br> Error (LSB) | Power <br> Dissipation (mW) | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD7853AN | $\pm 1$ | 18 | $\mathrm{~N}-24$ |
| AD7853BN | $\pm 1 / 2$ | 18 | $\mathrm{~N}-24$ |
| AD7853LAN | $\pm 1$ | 6.5 | $\mathrm{~N}-24$ |
| AD7853LBN | $\pm 1 / 2$ | 6.5 | $\mathrm{~N}-24$ |
| AD7853AR | $\pm 1$ | 18 | $\mathrm{R}-24$ |
| AD7853BR | $\pm 1 / 2$ | 18 | $\mathrm{R}-24$ |
| AD7853LAR | $\pm 1$ | 6.5 | $\mathrm{R}-24$ |
| AD7853LBR | $\pm 1 / 2$ | 6.5 | $\mathrm{R}-24$ |
| AD7853LARS | $\pm 1$ | 6.5 | $\mathrm{RS}-24$ |
| AD7858AN | $\pm 1$ | 18 | $\mathrm{~N}-24$ |
| AD7858BN | $\pm 1 / 2$ | 18 | $\mathrm{~N}-24$ |
| AD7858LAN | $\pm 1$ | 6.5 | $\mathrm{~N}-24$ |
| AD7858LBN | $\pm 1 / 2$ | 6.5 | $\mathrm{~N}-24$ |
| AD7858AR | $\pm 1$ | 18 | $\mathrm{R}-24$ |
| AD7858BR | $\pm 1 / 2$ | 18 | $\mathrm{R}-24$ |
| AD7858LAR | $\pm 1$ | 6.5 | $\mathrm{R}-24$ |
| AD7858LBR | $\pm 1 / 2$ | 6.5 | $\mathrm{R}-24$ |
| AD7858LARS | $\pm 1$ | 6.5 | $\mathrm{RS}-24$ |

${ }^{\star}$ For outline information see Package Information section.


NOTE: $t_{\text {CONVERT }}=\mathbf{4 . 5} \boldsymbol{\mu s}$ MAX, $t_{1}=100 \mathrm{~ns}$ MIN, $t_{5}=\mathbf{6 0} \mathrm{ns}$ MAX, $t_{6}=\mathbf{4 0} \mathrm{ns}$ MIN, $\mathrm{t}_{7}=\mathbf{0} \mathrm{ns}$ MIN.
Figure 2. AD7853 Timing Diagram (Typical Read or Write Operation)

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## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD7853/AD7858 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

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# AD7853/AD7858 

## AD7853 PIN DESCRIPTIONS

| Pin | Mnemonic | Description |
| :---: | :---: | :---: |
| 1 | CONVST | Convert start. Logic input. A low to high transition on this input puts the track/hold into its hold mode and starts conversion. |
| 2 | BUSY | Busy output. The busy output goes high when conversion begins (note that BUSY goes high before CONVST goes high) and stays high until conversion is completed, at which time it goes low. BUSY is also used to indicate when the AD 7853 has completed its on-chip calibration sequence. |
| 3 | $\overline{\text { SLEEP }}$ | Sleep input/Low power mode. With this pin logic low all circuitry is powered down including the internal voltage reference. Calibration data is retained. With the pin logic high normal operation results. |
| 4 | $\mathrm{REF}_{\text {IN }} / \mathrm{REF}_{\text {OUT }}$ | Reference input/output. This pin is connected to the internal reference via a resistor so that the reference voltage appears at this pin from the internal reference. An external reference can be applied to overdrive this pin. This pin is the reference source for the analog-to-digital converter, and the nominal reference voltage is 2.5 V but can be as high as $\mathrm{AV}_{\mathrm{DD}}$ to give a larger reference for the analog-to-digital converter. |
| 5 | $\mathrm{AV}_{\mathrm{DD}}$ | Analog positive supply voltage, +3.0 V to +5.5 V . |
| 6 | AGND | Analog ground. Ground reference for track/hold, reference and DAC. |
| 7 | $\mathrm{C}_{\text {REF1 }}$ | Reference capacitor ( $0.1 \mu \mathrm{~F}$ multilayer ceramic). This external capacitor is used as a charge source for the internal DAC. |
| 8 | $\mathrm{C}_{\text {REF2 }}$ | Reference capacitor ( $0.01 \mu \mathrm{~F}$ ceramic disc). This external capacitor is used in conjunction with the on-chip reference. |
| 9 | AIN(+) | Analog input. Positive input of the differential analog input. |
| 10 | AIN(-) | Analog input. Negative input of the differential analog inpu |
| 11, 12 | NC | No Connect pins. |
| 13 | AMODE | Analog mode pin. This pin allows two different analog input ranges to be selected: A logic 0 selects range 0 to $\mathrm{V}_{\text {Refin }}$ (i.e., $\operatorname{AIN}(+)-\operatorname{AIN}(-)=0$ to $\mathrm{V}_{\text {Refin }}$ ) A logic 1 selects range $-\mathrm{V}_{\text {REFIN }} / 2$ to $+\mathrm{V}_{\text {REFIN }} / 2$ (i.e., $\operatorname{AIN}(+)-\operatorname{AIN}(-)=-\mathrm{V}_{\text {REFIN }} / 2$ to $\left.+\mathrm{V}_{\text {REFIN }} / 2\right)$. |
| 14 | POLARITY | This pin determines the edge of the serial clock (SCLK) on which the data is latched and transferred to the DOUT pin or latched from the DIN pin. Depending on the mode of operation then the output data can be clocked out on the rising or falling edge of the serial clock (SCLK). The data input is always latched on the rising edge of the serial clock (SCLK) regardless of the state of the POLARITY pin. It is best to see the timing diagrams for each of the operating modes to see which edges of the SCLK are critical for the output data and for the input data. All the timing diagrams are with the POLARITY pin high, so bringing the POLARITY pin low will reverse the edge of the SCLK that the data input is latched in on and will also reverse the edge of the SCLK that the output data is clocked out on. |
| 15 | SM1 | Serial mode select pin. When this pin is high, the device is in its self-clocking mode; when it is low, the device is in its external clocking mode. This pin is used in conjunction with SM2 to give different modes of operation as shown in Table III. |
| 16 | SM2 | Serial mode select pin. This pin is used in conjunction with the SM1 pin in order to give the different modes of operation as shown in Table III. |
| 17 | $\overline{\text { CAL }}$ | Calibration input. A logic 0 on this input resets all logic and initiates a calibration on its rising edge. This input overrides all other internal operations. |
| 18 | DV ${ }_{\text {DD }}$ | Digital supply voltage, +3.0 V to +5.5 V . |
| 19 | DGND | Digital ground. Ground reference point for digital circuitry. |
| 20 | DOUT | Serial data output. The data output is supplied to this pin as a 16 -bit serial word. |
| 21 | DIN | Serial data input. The data to be loaded to the control register is applied to this pin in serial form (16-bit word). This pin can act as an input pin or as a I/O pin depending on the mode the part is in (see Table III). |
| 22 | CLKIN | Master clock signal for the device ( 4 MHz ). Sets the conversion and calibration times. |
| 23 | SCLK | Serial port clock. Logic input/output. The SCLK pin is configured as an input or output, dependent on the type of serial data transmission (self-clocking or external-clocking) that has been selected by the SM1 and SM2 pins. The data is latched on the rising or falling edge of SCLK depending on the POLARITY input logic level. |
| 24 | $\overline{\text { SYNC }}$ | This pin can be an input level triggered active low (similar to a chip select in one case and to a frame sync in the other case) or an output (similar to a frame sync) pin depending on SM1 and SM2 (see Table III). |

## AD7858 PIN DESCRIPTIONS

| Pin | Mnemonic | Description |
| :---: | :---: | :---: |
| 1 | CONVST | Convert start. Logic input. A low to high transition on this input puts the track/hold into its hold mode and starts conversion. If the CONVST is tied to the BUSY pin, then the part will go into sleep mode once conversion is complete and on the next conversion cycle the part needs to "wake-up" before a conversion can take place. |
| 2 | BUSY | Busy output. The busy output goes high when conversion begins (note that BUSY goes high before CONVST goes high) and stays high until conversion is completed, at which time it goes low. BUSY is also used to indicate when the AD7858 has completed its on-chip calibration sequence. |
| 3 | $\overline{\text { SLEEP }}$ | Sleep input/low power mode. With this pin logic low all circuitry is powered down including the internal voltage reference. Calibration data is retained. With the pin logic high normal operation results. |
| 4 | $\mathrm{REF}_{\text {IN }} / \mathrm{REF}_{\text {OUT }}$ | Reference input/output. This pin is connected to the internal reference via a resistor so that the reference voltage appears at this pin from the internal reference. An external reference can be applied to overdrive this pin. This pin is the reference source for the analog-to-digital converter and the nominal reference voltage is 2.5 V . However this pin can be taken as high as $\mathrm{AV}_{\mathrm{DD}}$ to give a larger reference for the analog-to-digital converter. |
| 5 | $\mathrm{AV}_{\mathrm{DD}}$ | Analog positive supply voltage, +3.0 V to +5.5 V . |
| 6 | AGND | Analog ground. Ground reference for track/hold, reference and DAC. |
| 7 | $\mathrm{C}_{\text {REF1 }}$ | Reference capacitor ( $0.1 \mu \mathrm{~F}$ multilayer ceramic). This external capacitor is used as a charge source for the internal DAC. |
| 8 | $\mathrm{C}_{\text {REF2 }}$ | Reference capacitor ( $0.01 \mu \mathrm{~F}$ ceramic disc). This external capacitor is used in conjunction with the on-chip reference. |
| 9-16 | $\mathrm{AIN}_{1}-\mathrm{AIN}_{8}$ | Analog inputs. Eight analog inputs which can be used as eight single ended inputs (referenced to AGND) or four pseudo differential inputs where $\operatorname{AIN}_{1}$ would be the positive input and $\operatorname{AIN}_{2}$ would be the negative input and similarly for pairs $\mathrm{AIN}_{3} \mathrm{AIN}_{4}, \mathrm{AIN}_{5} \mathrm{AIN}_{6}$, and $\mathrm{AIN}_{7} \mathrm{AIN}_{8}$. Pseudo differential means that the negative input cannot be taken below AGND. The selection of single ended or pseudo differential channels can be programmed via the SGL/ $\overline{\mathrm{DIFF}}$ bit in the control register, and also the channel to be selected for conversion can be programmed by the bits CHSLT0, CHSLT1, CHSLT2 in the control register. |
| 17 | $\overline{\text { CAL }}$ | Calibration input. A logic 0 on this input resets all logic and initiates a calibration on its rising edge. This input overrides all other internal operations (see Figure 5). |
| 18 | DV ${ }_{\text {DD }}$ | Digital supply voltage, +3.0 V to +5.5 V . |
| 19 | DGND | Digital ground. Ground reference point for digital circuitry. |
| 20 | DOUT | Serial data output. The data output is supplied to this pin as a 16 -bit serial word. |
| 21 | DIN | Serial data input. The data to be loaded to the control register is applied to this pin in serial form (16-bit word). This pin can act as an input pin or as a I/O pin depending on the mode the part is in (see Operating Modes). |
| 22 | CLKIN | Master clock signal for the device ( 4 MHz ). Sets the conversion and calibration times. |
| 23 | SCLK | Serial port clock. The SCLK pin is configured as an input pin, and the user must provide 16 clock pulses at this pin for correct operation. The input data is latched on the rising edge of SCLK, and the output data is clocked out on the falling edge of SCLK (see timing diagrams). |
| 24 | SYNC | The user must provide a frame sync signal at this pin and this signal is level triggered active low. This pin can be tied permanently low. When this input is high then the part will not read in the input data and output data will also be disabled. |

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## CONTROL/STATUS REGISTER

The power-up/default state of all bits in the control/status register is 0 .
When writing to the control register, the first two bits are used in determining whether it is the control/status register or the calibration register that is being written to. A 11 in the first two bits ensures that it is the control/status register that you are writing to, and a 10 tells the part that it is the calibration register that is being written to. Also a 00 in the first two bits does not have any effect and a 01 is not allowed.

| Bit | Mnemonic | Comment |
| :---: | :---: | :---: |
| 0 | STCAL | Start calibration bit. The type of calibration is determined by the setting of CALSLT1 and CALSLT2 and also whether it is a system or device calibration is set by the calibration mode (CALMD) bit. The default/Power up setting is for full device calibration (i.e., calibration of DAC, Offset, and Gain). |
| 1 | CALSLT1 | These two bits are for calibration control so that one can select the type of calibration that is to be |
| 2 | CALSLT2 | performed depending on the value of the bits. A 00 will give a full DAC + Offset + Gain calibration, a 01 will give an Offset + Gain calibration, a 10 combination will give just an Offset calibration, and a 11 will give a Gain calibration. The calibration can be a system or device calibration depending on the setting of the calibration mode bit (see Table I). |
| 3 | CALMD | This is the calibration mode bit. A 0 here selects the device itself for calibration and a 1 selects a system calibration. The default/power-up state is a 0 so that it is a device calibration is selected unless this bit is changed (see Table I). |
| 4 | CONVST | This is the conversion start bit. This is used for initiating a conversion start and it is also used in conjunction with system calibration as shown in the calibration timing diagram of Figure 6. |
| 5 | $2 / \overline{3} \mathrm{MODE}$ | The interface mode select bit. With this bit set to 1 the two-wire interface mode is enabled where DIN is used as an output as well as an input. |
| 6 | RDSLT1 | Theses two bits determine what data is going to be read from the part. ADC data will be read when the bits |
| 7 | RDSLT2 | are set to 00 , a 01 combination is used for test purposes and contains no useful user information, a 10 combination allows reading of the calibration register data, and a 11 ensures reading of control register data. |
| 8 | $\overline{\text { SLEEP }}$ | This is the sleep bit which puts the device anto sleep mode when 1 and the extent of the power down is determined by the power management bit. |
| 9 | PMGT | Power management bit. With this set to 0 then when put into sleep mode there will be a full power down whereas if set to 1 there will only be a selective power down. |
| 10 | *CHSLT0 | (AD7858 only, should be 0 for AD7853.) These three bits are used to select the channel to be converted. |
| 11 | *CHSLT1 | With three bits then we can address all the eight channels. One should refer to Table II for the combinations |
| 12 | *CHSLT2 | of these three bits for different channel selections. The default selection is the pseudo differential mode with positive channel AIN $_{1}$ and negative channel AIN $_{2}$. |
| 13 | *SGL/ $\overline{\text { DIFF }}$ | (AD7858 only, should be 0 for AD7853) This is the bit which determines whether the input channels are in the single ended mode or in the pseudo differential mode. With this bit set to 1 then the singled ended mode is enabled. The default setting of this bit is 0 so that the input channels are in the pseudo differential mode. This bit is used in conjunction with the three channel selection bits CHSLT0, CHSLT1, CHSLT2 and one should refer to Table II for the bit combinations for different selections. |
| 14 | BUSY | This is the conversion/calibration busy bit which is read only and tells you when the part is finished conversion or calibration. |

It is important to note that in writing to the control register it is Bit 15 (the MSB) that is the first bit in the data stream and not Bit 0 , so that the first bit to be written to the control register will be Bit 15 then Bit 14, Bit 13 and so on down to Bit 0 .
*These bits for the channel selection and the channel configuration are only valid for the AD7858 and for the AD7853 these bits must all be made 0 when writing to
the control register.

Shown below are the tables for the different types of calibration and the different types of configurations for the analog inputs (AD7858 only) that can be selected in the control register.

Table I. Calibration Selection in the Control Register (AD7853/AD7858)

| CALSLT2 | CALSLT1 | CALMD | Calibration Type |
| :--- | :--- | :--- | :--- |
| 0 | 0 | 0 | A full internal calibration is initiated where the internal DAC is calibrated then the <br> Internal Offset Error is calibrated out and finally the Internal Gain Error is calibrated out. <br> A full system calibration is initiated here where firstly the Internal DAC is calibrated <br> and then the System Offset Error is calibrated out and finally the System Gain Error <br> is calibrated out. |
| 0 | 0 | 1 | Here the Internal Offset Error is calibrated out and then the Internal Gain Error is <br> calibrated out. <br> Here the System Offset Error is calibrated out and then the System Gain Error is <br> calibrated out. |
| 0 | 1 | 1 | This calibrates out the Internal Offset Error only. |
| 1 | 0 | 0 | This calibrates out the System Offset Error only. <br> 1 |
| 1 | 1 | This calibrates out the Internal Gain Error only. |  |

NOTE
There is more information on the calibration features of the part under the Calibration section of this data sheet.
Table II. Multichannel Selection in the Control Register for the AD7858


NOTE
The four selection bits are in the control register.

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## TERMINOLOGY ${ }^{1}$

## Integral Nonlinearity

This is the maximum deviation from a straight line passing through the endpoints of the ADC transfer function. The endpoints of the transfer function are zero scale (which is $A I N(+)=$ AIN(-) -1/2 LSB in unipolar mode (AD7853/AD7858), and $\operatorname{AIN}(+)=\operatorname{AIN}(-)-V_{\text {REF }} / 2-1 / 2$ LSB in bipolar mode (AD7853 only) ), a point $1 / 2$ LSB below the first code transition ( $00 \ldots$ 000 to $00 \ldots 001$ ) and full scale (which is $\operatorname{AIN}(+)=\operatorname{AIN}(-)$ $+V_{R E F}+1 / 2$ LSB in unipolar range $e_{i}$ (AD7853/AD7858), and AIN $(+)=\operatorname{AIN}(-)+V_{R E F} / 2+1 / 2$ LSB in bipolar mode (AD7853 only) ), a point $1 / 2$ LSB above the last code transition (11 . . 110 to 11 . . 111).

## Differential Nonlinearity

This is the difference between the measured and the ideal 1 LSB change between any two adjacent codes in the ADC.

## Unipolar Offset Error

This is the deviation of the first code transition ( $00 \ldots 000$ to $00 \ldots 001$ ) from the ideal $\operatorname{AIN}(+)$ voltage (AIN(-) + $1 / 2 \mathrm{LSB}$ ) when operating in the unipolar mode.

## Positive Full-Scale Error

This applies to the unipolar and bipolar modes and is the deviation of the last code transition ( $11 \ldots 110$ to $11 \ldots 111$ (for unipolar mode (AD7853/AD7858)) and $01 \ldots 110$ to $01 \ldots 111$ (for bipolar mode (AD7853 only)) from the ideal (AIN $(+)=$ AIN(-) + Full Scale - 1.5 LSB) after the offset error (unipolar offset error or bipolar offset error) has been adjusted out.

## Negative Full-Scale Error

This applies to the bipolar mode only and is the deviation of the first code transition ( $10 \ldots 000$ to $10 \ldots 001$ ) from the ideal $\left(\operatorname{AIN}(+)=\mathrm{AIN}(-)-\mathrm{V}_{\mathrm{REF}} / 2+0.5 \mathrm{LSB}\right.$ (bipolar mode (AD7853 only))).

## Bipolar Zero Error

This is the deviation of the midscale transition (all 0 s to all 1 s ) from the ideal $\operatorname{AIN}(+$ ) voltage (AIN(-) - $1 / 2 \mathrm{LSB}$ ).

## Channel-to-Channel Isolation

Channel-to-channel isolation is a measure of the level of crosstalk between channels. It is measured by applying a fullscale 1 kHz signal to the other seven inputs and determining how much that signal is attenuated in the channel of interest. The figure given is the worst case for all channels.

## Track/Hold Acquisition Time

Track/hold acquisition time is the time required for the output of the track/hold amplifier to reach its final value, within $\pm 1 / 2 \mathrm{LSB}$, after the end of conversion (the point at which the track/hold returns into track mode). It also applies to a situation where a change in the selected input channel takes place (AD7858 only) or where there is a step input change on the input voltage applied to the selected $\mathrm{V}_{\text {IN }}$ input of the AD7853/AD7858. It means that the user must wait for the duration of the track/hold acquisition time after the end of conversion or after a channel change/step input change to $\mathrm{V}_{\mathrm{IN}}$ before starting another conversion, to ensure the part operates to specification.
${ }^{1} \mathrm{AIN}(-)$ refers to the negative input of the pseudo differential input pairs or to AGND for the AD7858 depending on the channel configuration, and $\operatorname{AIN}(-)$ refers to the negative input for the AD7853.

## Signal to (Noise + Distortion) Ratio

This is the measured ratio of signal to (noise + distortion) at the output of the A/D converter. The signal is the rms amplitude of the fundamental. Noise is the sum of all nonfundamental signals up to half the sampling frequency ( $\mathrm{f}_{\mathrm{s}} / 2$ ), excluding dc. The ratio is dependent on the number of quantization levels in the digitization process; the more levels, the smaller the quantization noise. The theoretical signal to (noise + distortion) ratio for an ideal N -bit converter with a sine wave input is given by:

$$
\text { Signal to }(\text { Noise }+ \text { Distortion })=(6.02 N+1.76) d B
$$

Thus for a 12-bit converter, this is 74 dB .

## Total Harmonic Distortion

Total harmonic distortion (THD) is the ratio of the rms sum of harmonics to the fundamental. For the AD7853, it is defined as:

$$
T H D(d B)=20 \log \sqrt{\left(V_{2}^{2}+V_{3}^{2}+V_{4}^{2}+V_{5}^{2}+V_{6}^{2}\right) / V_{1}}
$$

where $V_{1}$ is the rms amplitude of the fundamental and $V_{2}, V_{3}$, $\mathrm{V}_{4}, \mathrm{~V}_{5}$ and $\mathrm{V}_{6}$ are the rms amplitudes of the second through the sixth harmonics.

## Peak Harmonic or Spurious Noise

Peak harmonic or spurious noise is defined as the ratio of the rms value of the next largest component in the ADC output spectrum (up to $\mathrm{f}_{\mathrm{S}} / 2$ and excluding dc) to the rms value of the fundamental. Normally, the value of this specification is determined by the largest harmonic in the spectrum, but for parts where the harmonics are buried in the noise floor, it will be a noise peak.

## Intermodulation Distortion

With inputs consisting of sine waves at two frequencies, fa and fb , any active device with nonlinearities will create distortion products at sum and difference frequencies of $\mathrm{mfa} \pm \mathrm{nfb}$ where $\mathrm{m}, \mathrm{n}=0,1,2,3$, etc. Intermodulation distortion terms are those for which neither $m$ or $n$ are equal to zero. For example, the second order terms include ( $\mathrm{fa}+\mathrm{fb}$ ) and ( $\mathrm{fa}-\mathrm{fb}$ ), while the third order terms include $(2 \mathrm{fa}+\mathrm{fb}),(2 \mathrm{fa}-\mathrm{fb}),(\mathrm{fa}+2 \mathrm{fb})$ and (fa-2fb).
The AD7853 is tested using the CCIF standard where two input frequencies near the top end of the input bandwidth are used. In this case, the second order terms are usually distanced in frequency from the original sine waves while the third order terms are usually at a frequency close to the input frequencies. As a result, the second and third order terms are specified separately. The calculation of the intermodulation distortion is as per the THD specification where it is the ratio of the rms sum of the individual distortion products to the rms amplitude of the fundamental expressed in dBs .

[^43]Table III. Digital Interface Operating Modes

| No. | SM1 | SM2 | SYNC | DIN | DOUT | SCLK | Comment |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1 (AD7853/AD7858) | 0 | 0 | $\mathrm{I} / \mathrm{P}^{1}$ | I/O | (O/P) ${ }^{2}$ | I/P | TWO-WIRE MODE (8051). In this mode of operation the user must supply the serial clock (SCLK with a total of 16 clock cycles). This mode can only be entered by programming the interfaced mode select ( $2 / \overline{3} \mathrm{MODE}$ ) bit in the control register. The $\overline{\text { SYNC }}$ pin must also be provided by the user; it is level triggered and can be tied low permanently in this mode. The DIN pin is used for inputting the data (in serial form) as well as providing the output data in serial form. |
| 2 (AD7853/AD7858) | 0 | 0 | $\mathrm{I} / \mathrm{P}^{1}$ | I/P | O/P | I/P | THREE-WIRE MODE (SPI). In this mode of operation the user must supply the frame sync signal ( $\overline{\mathrm{SYNC}}$ ) and serial clock (SCLK with a total of 16 clock cycles). This is the default mode. Here the DOUT pin is used for the output data and DIN pin is used for the input data only. |
| 3 (AD7853 Only) | 0 | 1 | $\mathrm{I} / \mathrm{P}^{3}$ | I/P | O/P | I/P | DSP MASTER MODE. In this mode of operation a frame sync input is needed at the SYNC pin and a serial clock SCLK is needed with a continuous clock or 16 clock cycles from when the $\overline{\mathrm{SYNC}}$ goes low. |
| 4 (AD7853 Only) | 1 | 0 | $\mathrm{O} / \mathrm{P}^{3}$ | I/P | O/P | O/P ${ }^{4}$ | DSP SLAVE MODE. This mode of operation is where the part provides a noncontinuous serial clock (SCLK with a total of 16 clock cycles) and the frame sync ( $\overline{\mathrm{SYNC}}$ ). |
| 5 (AD7853 Only) | 1 | 1 | $\mathrm{O} / \mathrm{P}^{3}$ | I/P | $\mathrm{O} / \mathrm{P}$ | $\mathrm{O} / \mathrm{P}^{5}$ | This another DSP slave mode of operation where the part provides a CONTINUOUS CLOCK (TMS) signal (SCLK) and frame sync output ( $\overline{\mathrm{SYNC}}$ ). |

## NOTES

I/P: Input, I/O: Input/Output, O/P: Output
${ }^{1}$ SYNC pin is an input pin which is level triggered active low.
${ }^{2}$ Output data may appear at the DOUT pin but the pin is not used and should be left unconnected.
${ }^{3} \mathrm{~A}$ frame sync signal (input or output) which is edge triggered (high to low).
${ }^{4}$ Noncontinuous serial clock.
${ }^{5}$ Continuous serial clock.

## OPERATING SETUPS

From Table III it is clear that all the interface modes apply to the AD7853 (and AD7853L) but that only interface modes 1 and 2 apply to the AD7858 (and AD7858L). In all the timing diagrams the reference to the Polarity, SM1 and SM2 pins only applies to the AD7853. Next, before describing the operating modes in more detail, the different arrangements for reading, writing and starting conversions will be described.

The most useful arrangement is where the writing and reading takes place during conversion as shown in Figure 3. This allows for the maximum throughput rate ( $200 \mathrm{kHz} \mathrm{AD} 7853 / \mathrm{AD} 7858$, 100 kHz AD7853L/AD7858L). It is clear from Figure 3 that the read on the DOUT pin is for the previous conversion and the write on the DIN pin is for the next conversion.
The arrangement in Figure 3 is only valid for the three-wire mode and the DSP Master Mode (AD7853 only) of operation. The different arrangements for the other modes of operation are shown under the respective operating mode section.

There are other less common arrangements that can be used. These involve initiating a write in synchronization with the start of conversion and then waiting for the conversion to be complete


Figure 3.
before reading from the part. The reverse of this can also be used where a read is initiated in synchronization with the start of conversion, and writing to the part once the conversion is complete. Alternatively the conversion can be initiated by setting the CONVST bit in the control register to 1 when writing to the part. These arrangements are similar to the arrangements shown in Figures $4 \mathrm{c}, 4 \mathrm{~d}$, and 4 e for the two-wire mode of operation, but both the reading and writing would not take place on the DIN pin.

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## Timing

The two timing figures $t_{3}$ and $t_{10}$ need to be explained due to their complexity. Theses times apply to Figures $4 \mathrm{~d}, 4 \mathrm{e}$, 5a, 5b, and 6 only where the SYNC and the SCLK are both inputs to the part. For Figure 8 where $\overline{\text { SYNC }}$ and SCLK are outputs from the part, $t_{3 A}$ and $t_{10 \mathrm{~A}}$ are used and these are explained under the DSP Slave Mode section.

Taking $\mathrm{t}_{3}$ first and a continuous SCLK situation (which only applies for Figures $4 d, 5 a$ and 6), $\mathrm{t}_{3}$ has a minimum spec of 60 ns so that the part will have enough time to prepare for the first SCLK edge. The max spec for $\mathrm{t}_{3}$ (which only applies with a continuous $S C L K$ ) is $0.4 \mathrm{t}_{\text {SCLK }}$ which ensures that the $\overline{\mathrm{SYNC}}$ does not go low before the rising edge A of the dashed SCLK (shown in the timing diagrams). This ensures that the part does not clock in an incorrect data bit from the DIN pin as DB15.

Next take the time $\mathrm{t}_{10}$ and a continuous SCLK situation (again this only applies to Figures 4d, 5a and 6), $\mathrm{t}_{10}$ has a minimum spec of 30 ns which is so that the part will have enough time to prepare for the rising edge of $\overline{S Y N C}$. The max spec for $\mathrm{t}_{10}$ (which only applies with a continuous $S C L K$ ) is $0.4 \mathrm{t}_{\text {SCLK }}$ which ensures that the SYNC goes high before the falling edge B of the dashed SCLK (shown in the timing diagrams). This ensures that the part does not offset the next write sequence and also so that an extra bit will not be clocked out onto the DOUT pin.
Both $t_{3}$ and $t_{10}$ only have a minimum spec when there is a noncontinuous SCLK to allow the part enough time to prepare for the following edge of the relevant signal. There is no maximum spec for $t_{3}$ and $t_{10}$ as there is no danger of getting an extra clock edge to upset the operation of the part.

## Two-Wire Mode (AD7853 and AD7858)

The different setup arrangements for reading and writing to the part in the two-wire mode are shown in Figures $4 a, 4 b$, and $4 c$. The read and writing takes place on the DIN line and the conversion start take place on the CONVST line. (Note that the write to the part must set the $2 / \overline{3}$ MODE bit in the control register to 1 for all cases $4 \mathrm{a}, 4 \mathrm{~b}, 4 \mathrm{c}$. Also the conversion can be started by setting the CONVST bit in the control register to 1 , and so the CONVST pin does not need to be used in cases 4 b and 4 c .)
In Figure 4a a write is initiated in synchronization with the start of a conversion cycle (thus with this setup the write cannot initiate the start of conversion via the control register, but the $2 \overline{3}$ MODE bit must be set to 1 in all the write sequences to the part ). Then after the conversion is finished, a read operation is started and the data read here is from conversion $\mathrm{N}-1$ and does not correspond to the previous write. You must wait until the next conversion (conversion N ) before reading data corresponding to the initial write (write N ). The very first read from the part here will not contain a result from a conversion under the two-wire mode due to the fact that the write sequence is one sequence behind the conversion sequence. The time for the read and write operation
given is for a serial clock of $4 \mathrm{MHz}(2 \mathrm{MHz}$ is max for $L$ versions), but is still only an approximate time. Thus the $9.5 \mu \mathrm{~s}$ shown is the fastest throughput time for the two-wire interface operating mode which corresponds to a frequency of 105 kHz ( 52 kHz for $L$ versions).


Figure 4 a.
Figure $4 b$ is the same as Figure 4 a except that the conversion is initiated in synchronizations with a read operation instead of a write operation. Again the data read from the part is one conversion behind the corresponding write operation. (The write to the part must enable the two-wire mode and may also initiate a conversion, and so the hardware CONVST signal is not needed.)


Figure $4 b$.
Figure 4 c shows another way of operating the part in the twowire mode where getting the fastest throughput rate is not essential. It is the most basic way to operate the part. A write is initiated (which enables the two-wire mode and may also initiate the start of conversion). After this a conversion is started, and when conversion is complete, the result is read back. From these diagrams it can be seen that the part cannot be run at its max throughput rate in the two-wire mode due to the time taken to read and write data on the same pin.


Figure 4c.

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## AD7853/AD7858

Below in Figure 4d and in Figure 4e are the timing diagrams for operating mode No. 1 in Table I where we are in the 2 -wire interface mode. Here the DIN pin is used for both input and output as shown. The $\overline{S Y N C}$ input is level triggered active low and can be pulsed (Figure 4d) or can be constantly low (Figure 4e).
In Figure 4 a the part samples the input data on the rising edge of SCLK. When the SYNC is taken high, the DIN pin is configured as an output and is then 3-stated. Taking SYNC low disables the 3 -state on the DIN pin, and the first SCLK falling edge clocks out the first data bit. Once the 16 clocks have been provided and the $\overline{\text { SYNC }}$ taken high, the DIN pin will automatically revert back to being an input after a time $t_{11}$. Note that a continuous SCLK shown by the dotted waveform in Figure 4d can be used provided that the $\overline{\text { SYNC }}$ is low for only 16 clock pulses in each of the read and write cycles.

In Figure 4 e the $\overline{\mathrm{SYNC}}$ line is tied low permanently, and this results in a different timing arrangement for the DIN pin. The difference between $\overline{\text { SYNC }}$ being tied low and being pulsed is that the DIN pin will never be 3 -stated in this mode, and it is also the last rising edge of the SCLK that causes the DIN pin to go from being an input to an output and back to an input pin. Here a continuous SCLK cannot be used as the SYNC is tied low permanently.


Figure 4d. Timing Diagram for Read/Write Operations with DIN as an Input/Output (i.e., Operating Mode No. 1, SM1 = SM2 = 0)


Figure 4e, Timing Diagram for Read/Write Operations with DIN as an Input/Output and $\overline{S Y N C}$ Input Tied Low (i.e., Operating Mode No. 1, SM1 = SM2 = 0)

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## Three-Wire Mode (AD7853 and AD7858)

In Figure 5a and Figure 5b we have the timing diagrams for operating mode No. 2 in Table I which is the three-wire interface mode. Here the SYNC input is active low and can be pulsed (Figure 5a) or can be constantly low, (Figure 5b). If SYNC is constantly low, the serial clock input (SCLK) must supply 16 clock pulses for the part to operate correctly; otherwise with a pulsed $\overline{\text { SYNC }}$ input, a continuous SCLK can be used provided $\overline{\text { SYNC }}$ is low for only 16 clock cycles. In Figure 5a the $\overline{\text { SYNC }}$ going low disables the 3 -state on the DOUT pin. The first falling edge of the SCLK after the SYNC going low clocks out the first leading zero on the DOUT pin. The DOUT
pin is 3 -stated again a time $t_{11}$ after the $\overline{\text { SYNC }}$ goes high. With the DIN pin the data input has to be set up a time $t_{6}$ before the SCLK rising edge as the part samples the input data on the SCLK rising edge.
Figure 5 b shows the timing diagram for the three-wire interface mode where the $\overline{\mathrm{SYNC}}$ input has been tied permanently low. The only difference between this timing diagram and the one in Figure 5 a is that the DOUT pin is never 3-stated since the $\overline{\text { SYNC }}$ input is never brought high. Also the LSB of the output data will remain on the DOUT pin until the next read cycle where the first SCLK falling edge will clock out the first leading zero of the next conversion.


Figure 5a. Timing Diagram for Read/Write Operations with DIN as an Input and DOUT as Output and $\overline{\text { SYNC }}$ Input Pulsed (i.e., Operating Mode No 2, SM1 $=$ SM12 $=0$ )


Figure 5b. Timing Diagram for Read/Write Operations with DIN as an Input and DOUT as Output and $\overline{S Y N C}$ Input Tied Low (i.e., Operating Mode No. 2, SM1 = SM2 = 0)

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## AD7853/AD7858



Figure 6. Timing Diagram for Read/Write Operation with $\overline{S Y N C}$ Input Edge Triggered (i.e., Operating Mode No. 3, SM1 = 0 SM2 = 1)

## DSP Master Mode (AD7853 Only)

In Figure 6 the timing diagram for operating mode No. 3 is shown. In this mode the DSP is the master and the part is the slave. Here the $\overline{S Y N C}$ input is edge triggered going from high to low, and the 16 clock pulses are counted from this edge so that you can have a continuous clock input or a noncontinuous clock input that provides 16 clock pulses after the falling edge of the $\overline{\text { SYNC input. If a continuous clock is being used, the SYNC }}$ must go high after 16 clock pulses to disable the effect of any more clocks. The falling edge of $\overline{\text { SYNC }}$ disables the 3-state on the DOUT pin, and the data is clocked out on the falling edge of SCLK. Once SYNC goes high, the 3 -state on the DOUT pin is enabled. The data input is sampled on the rising edge of SCLK and thus has to be valid a time $t_{6}$ before this rising edge.

## DSP Slave Mode (AD7853 Only) (Continuous and

 Noncontinuous SCLK)The timing diagram here is for operating mode Nos. 4 and 5, the only difference being the continuous and noncontinuous clock outputs. These modes of operation are especially different from all the other modes since the SCLK and SYNC are outputs. The SYNC is generated by the part as is the SCLK, and the dotted line shows the case of the continuous clock. The master clock at the CLKIN pin is routed directly to the SCLK pin for operating mode No. 5 (Continuous SCLK), and the CLKIN input is gated with the SYNC to give the SCLK in operating mode No. 4 (Noncontinuous SCLK).
The most important point about these two operation modes is that the result of the current conversion is clocked out during the same conversion, and a write to the part during this conversion is for the next conversion. The arrangement is shown in Figure 7. First the conversion is initiated with the CONVST signal going low, and then when part is ready, the SYNC will go low and the SCLK will clock out the data on the DOUT pin
during conversion. Also the data on the DIN pin is clocked in by the same SCLK for the next conversion. All the timing waveforms in Figure 8 are during conversion. Thus in these two modes of operation the maximum throughput rate of 200 kHz (AD7853) and 100 kHz (AD7853L) can be obtained with the added advantage that the result read during conversion is the result of the current conversion and not the result of the previous as in the other modes of operation.
In these modes the part is now the master and the DSP is the slave. The output data is clocked out from the part to the DOUT pin on the rising edge of SCLK, and the input data to the part on the DIN pin is also clocked in to the part on the rising edge of the SCLK.


Figure 7.
Some of the timing numbers for the timing diagram of Figure 8 need explaining due to their complexity. First, $t_{3 A}$ has only a $\min$ spec and no max spec as the part will ensure that the $\overline{\text { SYNC }}$

[^44] Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.


Figure 8. Timing Diagram for Read/Write with $\overline{\text { SYNC }}$ Output and SCLK Output (Continuous and Noncontinuous) (i.e., Operating Mode Nos. 4 and 5, SM1 = 1, SM2 = 1 and 0 )
goes low after the rising edge C of the dashed SCLK in Figure 8 (if there is a continuous SCLK) so that the part will not clock in an incorrect data bit from the DIN pin as DB15. The other time is $\mathrm{t}_{10 \mathrm{~A}}$ which again only has a min spec and no max spec as the part will again ensure that the SYNC has gone high before the rising edge D of the dashed SCLK in Figure 8 (if there is a continuous SCLK). This ensures both that the SCLK will not clock in an extra bit from the DIN pin which would offset the next write sequence, and also that another bit will not be clocked out of the part onto the DOUT pin.

## CALIBRATION

There are two main calibration features on the AD7853/
AD7858; these are a self or device calibration and a system calibration. For both system and self-calibrations there are a number of different types of calibration that can be selected depending on the setting of various bits in the control register. These options are covered by Table I.
There are a number of points that are useful to state before describing the procedure for initiating a system calibration. The first point is that the maximum calibration range is approximately $\pm 3 \%$ of $\mathrm{V}_{\text {REF }}$ for both the system offset and gain errors. Also, if the errors are outside this range, the system calibration algorithm will reduce the errors as much as the trim range
allows. Large system errors can be reduced in an incremental fashion by doing multiple system (gain + offset) calibrations. This is possible due to the way that the system calibration algorithm works. In bipolar mode (AD7853 only) it is the midscale error and the positive full-scale error that are adjusted; in unipolar mode it is the zero-scale error and the positive full-scale error that are adjusted.

## System Calibration

The calibration timing diagram in Figure 9 is for a system calibration where the falling edge of CAL initiates an internal reset before starting a calibration. (Note that if the part is in the autoshut-off mode where BUSY is connected to SLEEP so that the pari goes into sleep mode after conversion, then $t_{1}$ will be as for the CONVST to allow for the "wake-up" time; again depending on the type of sleep mode that the part is in, there will be different "wake$u p$ " times.) Then the rising edge of CAL starts calibration of the internal DAC. Then if the control register is set for a full calibration, the CONVST must be used also. The full-scale system voltage should be applied to the analog input pins from the start of calibration. Then the offset voltage due to the system must be present on the AIN pin (after the full-scale system offset is completed) for a minimum setup time ( $\mathrm{t}_{\text {SETUP }}$ ) of 100 ns before the rising edge of the CONVST.


Figure 9. Calibration Timing Diagram for Full System Calibration

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## Self-Calibration

For a self or device calibration the procedure is similar to that of the calibration timing diagram of Figure 9, but the BUSY line will stay high for the full length of the self-calibration and will not pulse like in the system calibration diagram. So a selfcalibration is initiated by bringing the CAL pin low (which initiates an internal reset as in system calibration) and then high again. (Note that if the part is in the autoshut-off mode where BUSY is connected to $\overline{\text { SLEEP }}$ so that the part goes into sleep mode after conversion, then $t_{1}$ will be as for the CONVST to allow for the "wakeup" time; again depending on the type of sleep mode that the part is in, there will be different "wake-up" times.) The BUSY line is triggered high from the rising edge of $\overline{\mathrm{CAL}}$ and BUSY will go low when the self-calibration is complete.

## POWER-DOWN MODES

There are two power-down modes on the part, one being a full power down, the other a selective power down where only certain internal circuitry is powered down. The advantage of the selective power down is that the part will not require as much time to "wake up" as for the full power down. The type of power down is selected by programming the power management bit (PMGT) in the control register, 0 for a full power down and 1 for a selective power down.

There is an automatic power-down mode which is achieved by connecting the BUSY pin to the SLEEP pin where the part goes into power-down mode after the end of conversion. Again the power management bit (PMGT) in the control register determines whether this is a full or selective power down. With this setup the part will take longer to "wake-up" than in the normal mode, and this time will also depend on the capacitor connected to the $\mathrm{C}_{\mathrm{REF}}$ pins. Table IV contains power-up times for different values of capacitors connected to the $\mathrm{C}_{\text {REF }}$ pins and for the two different power-down modes (full power down or selective power down).

Table IV.

| $\mathbf{C}_{\text {REF1 }}$ <br> $(\mu \mathbf{F})$ | $\mathbf{C}_{\text {REF2 }}$ <br> $(\mu \mathbf{F})$ | Power-Down Mode | Power-Up Delay <br> $(\mathbf{s e c})$ |
| :--- | :--- | :--- | :--- |
| 0.1 | 0.01 | Full | TBD |
| 0.1 | 0.01 | Selective | TBD |
| 1.0 | 0.1 | Full | TBD |
| 1.0 | 0.1 | Selective | TBD |

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FEATURES
Complete Monolithic 12-Bit ADC with:
$2 \mu \mathrm{~s}$ Track/Hold Amplifier
$8 \mu \mathrm{~s}$ A/D Converter
On-Chip Reference
Laser-Trimmed Clock
Parallel, Byte and Serial Digital Interface
72 dB SNR at 10 kHz Input Frequency (AD7870, AD7870A, AD7875)
57 ns Data Access Time
Low Power -60 mW typ
Variety of Input Ranges:
$\pm 3 \mathrm{~V}$ for AD7870/AD7870A
0 to +5 V for AD7875
$\pm 10 \mathrm{~V}$ for AD7876

## GENERAL DESCRIPTION

The AD7870/AD7870A/AD7875/AD7876 is a fast, complete, 12-bit A/D converter. It consists of a track/hold amplifier, $8 \mu \mathrm{~s}$ successive-approximation ADC, 3 V buried Zener reference and versatile interface logic. The ADC features a self-contained internal clock which is laser trimmed to guarantee accurate control of conversion time. No external clock timing components are required; the on-chip clock may be overridden by an external clock if required.
The parts offer a choice of three data output formats: a single, parallel, 12 -bit word; two 8 -bit bytes, or serial data. Fast bus access times and standard control inputs ensure easy interfacing to modern microprocessors and digital signal processors.
All parts operate from $\pm 5 \mathrm{~V}$ power supplies. The AD7870 and AD7876 accept input signal ranges of $\pm 3 \mathrm{~V}$ and $\pm 10 \mathrm{~V}$, respectively, while the AD7875 accepts a unipolar 0 to +5 V input range. The parts can convert full power signals up to 50 kHz .

The AD7870/AD7870A/AD7875/AD7876 feature dc accuracy specifications such as linearity, full-scale and offset error. In addition, the AD7870/AD7870A and AD7875 are fully specified for dynamic performance parameters including distortion and signal-to-noise ratio.
The parts are fabricated in Analog Devices' Linear Compatible CMOS (LC ${ }^{2}$ MOS) process, a mixed technology process that combines precision bipolar circuits with low-power CMOS logic. The parts are available in a 24 -pin, 0.3 inch-wide, plastic or hermetic dual-in-line package (DIP). The AD7870/AD7870A and AD7875 are available in a 28 -pin plastic leaded chip carrier (PLCC), while the AD7876 is available and in a 24 -pin small outline (SOIC) package.

FUNCTIONAL BLOCK DIAGRAM


## PRODUCT HIGHLIGHTS

1. Complete 12-Bit ADC on a Chip.

The AD7870/AD7870A/AD7875/AD7876 provides all the functions necessary for analog-to-digital conversion and combines a 12-bit ADC with internal clock, track/hold amplifier and reference on a single chip.
2. Dynamic Specifications for DSP Users.

The AD7870/AD7870A and AD7875 are fully specified and tested for ac parameters, including signal-to-noise ratio, harmonic distortion and intermodulation distortion.
3. Fast Microprocessor Interface.

Data access times of 57 ns make the parts compatible with modern 8 - and 16-bit microprocessors and digital signal processors. Key digital timing parameters are tested and guaranteed over the full operating temperature range.

[^45]AD7870/AD7870A/AD7875/AD7876 - SPECIFICATIONS ${ }_{w_{m}=+5 v \pm s \%} v_{s}$ $=-5 \mathrm{~V} \pm 5 \%$, AGND $=$ DGND $=0 \mathrm{~V}, \mathrm{f}_{\text {CLK }}=2.5 \mathrm{MHz}$ external, unless otherwise stated. All Specifications $\mathrm{T}_{\min }$ to $\mathrm{T}_{\text {max }}$ unless otherwise noted.)


[^46]

[^47]TIMING CHARACTERISTICS ${ }^{1,2}\left(V_{D D}=+5 V \pm 5 \%, V_{S S}=-5 V \pm 5 \%\right.$, AGND $=D G N D=0 V$. See Figures 9,10 , 11 and 12.$)$

| Parameter | Limit at $\mathbf{T}_{\text {min }}, T_{\text {max }}$ (J, K, L, A, B, C Versions) | Limit at $\mathrm{T}_{\text {min }}, \mathrm{T}_{\text {max }}$ (S, T Versions) | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{1}$ | 50 | 50 | ns min | CONVST Pulse Width |
| $\mathrm{t}_{2}$ | 0 | 0 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{RD}}$ Setup Time (Mode 1) |
| $\mathrm{t}_{3}$ | 60 | 75 | ns min | RD Pulse Width |
| $\mathrm{t}_{4}$ | 0 | 0 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{RD}}$ Hold Time (Mode 1) |
| $\mathrm{t}_{5}$ | 70 | 70 | ns max | $\overline{\mathrm{RD}}$ to INT Delay |
| $\mathrm{t}_{6}{ }^{3}$ | 57 | 70 | ns max | Data Access Time after $\overline{\mathrm{RD}}$ |
| $\mathrm{t}_{7}{ }^{4}$ | 5 | 5 | ns min | Bus Relinquish Time after $\overline{\mathrm{RD}}$ |
|  | 50 | 50 | ns max |  |
| $\mathrm{t}_{8}$ | 0 | 0 | ns min | HBEN to $\overline{\mathrm{RD}}$ Setup Time |
| $\mathrm{t}_{9}$ | 0 | 0 | ns min | HBEN to $\overline{\mathrm{RD}}$ Hold Time |
| $\mathrm{t}_{10}$ S | 100 | 100 | ns min | $\overline{\text { SSTRB }}$ to SCLK Falling Edge Setup Time |
| $\mathrm{t}_{11}{ }_{6}$ | 370 | 370 | ns min | SCLK Cycle Time |
| $\mathrm{t}_{12}{ }^{6}$ | 135 | 150 | ns max | SCLK to Valid Data Delay. $\mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}$ |
| $\mathrm{t}_{13}$ | 20 | 20 | ns min | SCLK Rising Edge to $\overline{\text { SSTRB }}$ |
|  | 100 | 100 | ns max |  |
| $\mathrm{t}_{14}$ | 10 | 10 | ns min | Bus Relinquish Time after SCLK |
|  | 100 | 100 | ns max |  |
| $\mathrm{t}_{15}$ | 60 | 60 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{RD}}$ Setup Time (Mode 2) |
| $\mathrm{t}_{16}$ | 120 | 120 | ns max | $\overline{\mathrm{CS}}$ to BUSY Propagation Delay |
| $\mathrm{t}_{17}$ | 200 | 200 | ns min | Data Setup Time Prior to $\overline{\text { BUSY }}$ |
| $\mathrm{t}_{18}$ | 0 | 0 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{RD}}$ Hold Time (Mode 2) |
| $\mathrm{t}_{19}$ | 0 | 0 | ns min | HBEN to $\overline{\mathrm{CS}}$ Setup Time |
| $\mathrm{t}_{20}$ | 0 | 0 | ns min | HBEN to $\overline{\mathrm{CS}}$ Hold Time |

## NOTES

${ }^{1}$ Timing specifications in bold print are $100 \%$ production tested. All other times are sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance. All input signals are specified with $\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of 5 V$)$ and timed from a voltage level of 1.6 V .
${ }^{2}$ Serial timing is measured with a $4.7 \mathrm{k} \Omega$ pull-up resistor on SDATA and SSTRB and a $2 \mathrm{k} \Omega$ pull-up on SCLK. The capacitance on all three outputs is 35 pF .
${ }^{3} t_{6}$ is measured with the load circuits of Figure 1 and defined as the time required for an output to cross 0.8 V or 2.4 V .
${ }^{4} \mathrm{t}_{7}$ is defined as the time required for the data lines to change 0.5 V when loaded with the circuits of Figure 2 .
${ }^{5}$ SCLK mark/space ratio (measured from a voltage level of 1.6 V ) is $40 / 60$ to $60 / 40$.
${ }^{6}$ SDATA will drive higher capacitive loads but this will add to $t_{12}$ since it increases the external RC time constant $\left(4.7 \mathrm{k} \Omega\left|\mid \mathrm{C}_{\mathrm{L}}\right)\right.$ and hence the time to reach 2.4 V . Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS*

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Extended (S, T Versions)
Storage Temperature Range . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 sec ) . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Power Dissipation (Any Package) to $+75^{\circ} \mathrm{C}$. . . . . . 450 mW
Derates above $+75^{\circ} \mathrm{C}$ by . . . . . . . . . . . . . . . . . $10 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.


Figure 1. Load Circuits for Access Time


Figure 2. Load Circuits for Output Float Delay

## CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are inserted.


## AD7870 ORDERING GUIDE

| Model ${ }^{1,2}$ | Temperature Range | $\mathbf{V}_{\text {IN }}$ Voltage Range (V) | $\begin{aligned} & \text { SNR } \\ & (\mathrm{dBs}) \end{aligned}$ | Integral Nonlinearity (LSB) | Package Option ${ }^{3}$ |
| :---: | :---: | :---: | :---: | :---: | :---: |
| AD7870AJN | 0 to $+70^{\circ} \mathrm{C}$ | $\pm 3$ | 70 min | $\pm 1 / 2$ typ | N-24 |
| AD7870JN | 0 to $+70^{\circ} \mathrm{C}$ | $\pm 3$ | 70 min | $\pm 1 / 2$ typ | N-24 |
| AD7870KN | 0 to $+70^{\circ} \mathrm{C}$ | $\pm 3$ | 70 min | $\pm 1$ max | $\mathrm{N}-24$ |
| AD7870LN | 0 to $+70^{\circ} \mathrm{C}$ | $\pm 3$ | 72 min | $\pm 1 / 2$ max | N-24 |
| AD7870JP | 0 to $+70^{\circ} \mathrm{C}$ | $\pm 3$ | 70 min | $\pm 1 / 2$ typ | P-28A |
| AD7870KP | 0 to $+70^{\circ} \mathrm{C}$ | $\pm 3$ | 70 min | $\pm 1$ max | P-28A |
| AD7870LP | 0 to $+70^{\circ} \mathrm{C}$ | $\pm 3$ | 72 min | $\pm 1 / 2$ max | P-28A |
| AD7870AQ | $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 3$ | 70 min | $\pm 1 / 2$ typ | Q-24 |
| AD7870BQ | $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 3$ | 70 min | $\pm 1$ max | Q-24 |
| AD7870CQ | $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 3$ | 72 min | $\pm 1 / 2$ max | Q-24 |
| AD7870SQ ${ }^{4}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\pm 3$ | 69 min | $\pm 1 / 2$ typ | Q-24 |
| AD7870TQ ${ }^{4}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\pm 3$ | 69 min | $\pm 1$ max | Q-24 |

## NOTES

${ }^{1}$ To order MIL-STD-883, Class B, processed parts, add /883B to part number. Contact local sales office for military data sheet.
${ }^{2}$ Contact local sales office for LCCC (Leadless Ceramic Chip Carrier) availability.
${ }^{3} \mathrm{~N}=$ Narrow Plastic DIP; P = Plastic Leaded Chip Carrier (PLCC); $\mathrm{Q}=$ Cerdip. For outline information see Package Information section.
${ }^{4}$ Available to $/ 883 \mathrm{~B}$ processing only.

## AD7875 ORDERING GUIDE

| Model ${ }^{1}$ | Temperature Range | $\mathbf{V}_{\text {IN }}$ Voltage <br> Range (V) | $\begin{aligned} & \text { SNR } \\ & (\mathrm{dBs}) \end{aligned}$ | Integral <br> Nonlinearity <br> (LSB) | Package Option ${ }^{2}$ |
| :---: | :---: | :---: | :---: | :---: | :---: |
| AD7875KN | 0 to $+70^{\circ} \mathrm{C}$ | 0 to +5 | 70 min | $\pm 1$ max | $\mathrm{N}-24$ |
| AD7875LN | 0 to $+70^{\circ} \mathrm{C}$ | 0 to +5 | 72 min | $\pm 1 / 2$ max | $\mathrm{N}-24$ |
| AD7875KR | 0 to $+70^{\circ} \mathrm{C}$ | 0 to +5 | 70 min | $\pm 1$ max | R-24 |
| AD7875KP | 0 to $+70^{\circ} \mathrm{C}$ | 0 to +5 | 70 min | $\pm 1 \mathrm{max}$ | P-28A |
| AD7875LP | 0 to $+70^{\circ} \mathrm{C}$ | 0 to +5 | 72 min | $\pm 1 / 2$ max | P-28A |
| AD7875BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 0 to +5 | 70 min | $\pm 1$ max | Q-24 |
| AD7875CQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 0 to +5 | 72 min | $\pm 1 / 2$ max | Q-24 |
| $\mathrm{AD}^{\text {7 }}$ 75TS ${ }^{3}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 0 to +5 | 69 min | $\pm 1$ max | Q-24 |

NOTES
${ }^{1}$ To order MIL-STD-883, Class B, processed parts, add /883B to part number. Contact
local sales office for military data sheet.
${ }^{2} N=$ Narrow Plastic DIP; $P=$ Plastic Leaded Chip Carrier (PLCC); $Q=$ Cerdip; $R=$ Small Outline IC (SOIC).
For outline information see Package Information section.
${ }^{3}$ Available to $/ 883 \mathrm{~B}$ processing only.

## AD7876 ORDERING GUIDE

| Model $^{\mathbf{1}}$ | Temperature <br> Range | $\mathbf{V}_{\text {IN }}$ Voltage <br> Range (V) | Integral <br> Nonlinearity <br> (LSB) | Package <br> Option |
| :--- | :--- | :---: | :--- | :--- |
| AD7876BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 10$ | $\pm 1 \mathrm{max}$ | $\mathrm{N}-24$ |
| AD7876CN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 10$ | $\pm 1 / 2 \mathrm{max}$ | $\mathrm{N}-24$ |
| AD7876BR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 10$ | $\pm 1 \max$ | $\mathrm{R}-24$ |
| AD7876CR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 10$ | $\pm 1 / 2 \max$ | $\mathrm{R}-24$ |
| AD7876BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 10$ | $\pm 1 \max$ | $\mathrm{Q}-24$ |
| AD7876CQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 10$ | $\pm 1 / 2 \max$ | $\mathrm{Q}-24$ |
| AD7876TQ $^{3}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\pm 10$ | $\pm 1$ max | $\mathrm{Q}-24$ |

## NOTES

${ }^{1}$ To order MIL-STD-883, Class B, processed parts, add /883B to part number. Contact local sales office for military data sheet.
${ }^{2} \mathrm{~N}=$ Narrow Plastic DIP; Q = Cerdip; R = Small Outline IC (SOIC). For outline information see Package Information section.
${ }^{3}$ Available to $/ 883 \mathrm{~B}$ processing only.

## PIN FUNCTION DESCRIPTION

| DIP | Pin |  |
| :---: | :---: | :---: |
| Pin No. | Mnemonic | Function |
| 1 | $\overline{\mathrm{RD}}$ | Read. Active low logic input. This input is used in conjunction with $\overline{\mathrm{CS}}$ low to enable the data outputs. |
| 2 | BUSY/INT | Busy/Interrupt, Active low logic output indicating converter status. See timing diagrams. |
| 3 | CLK | Clock input. An external TTL-compatible clock may be applied to this input pin. Alternatively, tying this pin to $\mathrm{V}_{\mathrm{SS}}$ enables the internal laser-trimmed clock oscillator. |
| 4 | DB11/HBEN | Data Bit 11 (MSB)/High Byte Enable. The function of this pin is dependent on the state of the $12 / \overline{8} / \mathrm{CLK}$ input (see below). When 12-bit parallel data is selected, this pin provides the DB11 output. When byte data is selected, this pin becomes the HBEN logic input. HBEN is used for 8-bit bus interfacing. When HBEN is low, DB7/LOW to DB0/DB8 become DB7 to DB0. With HBEN high, DB7/LOW to DB0/DB8 are used for the upper byte of data (see Table I). |
| 5 | DB10/ $\overline{\text { SSTRB }}$ | Data Bit $10 /$ Serial Strobe. When 12-bit parallel data is selected, this pin provides the DB10 output. $\overline{\text { SSTRB }}$ is an active low open-drain output that provides a strobe or framing pulse for serial data. An external $4.7 \mathrm{k} \Omega$ pull-up resistor is required on SSTRB. |
| 6 | DB9/SCLK | Data Bit $9 /$ Serial Clock. When 12 -bit parallel data is selected, this pin provides the DB9 output. SCLK is the gated serial clock output derived from the internal or external ADC clock. If the $12 / \overline{8} / \mathrm{CLK}$ input is at -5 V , then SCLK runs continuously. If $12 / \overline{8} / \mathrm{CLK}$ is at 0 V , then SCLK is gated off after serial transmission is complete. SCLK is an open-drain output and requires an external $2 \mathrm{k} \Omega$ pull-up resistor. |
| 7 | DB8/SDATA | Data Bit 8/Serial Data. When 12-bit parallel data is selected, this pin provides the DB8 output. SDATA is an opendrain serial data output which is used with SCLK and SSTRB for serial data transfer. Serial data is valid on the falling edge of SCLK while SSTRB is low. An external $4.7 \mathrm{k} \Omega$ pull-up resistor is required on SDATA. |
| 8-11 | DB7/LOWDB4/LOW | Three-state data outputs which are controlled by $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$. Their function depends on the $12 / \overline{8} / \mathrm{CLK}$ and HBEN inputs. With $12 / \overline{8} / \mathrm{CLK}$ high, they are always DB7-DB4. With $12 / \overline{8} / \mathrm{CLK}$ low or -5 V , their function is controlled by HBEN (see Table I). |
| 12 | DGND | Digital Ground. Ground reference for digital circuitry. |
| 13-16 | $\begin{aligned} & \text { DB3/DB11- } \\ & \text { DB0/DB8 } \end{aligned}$ | Three-state data outputs which are controlled by $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$. Their function depends on the $12 / \overline{8} / \mathrm{CLK}$ and HBEN inputs. With $/ 12 / \overline{8} / \mathrm{CLK}$ high, they are always DB3-DB0. With $12 / \overline{8} / \mathrm{CLK}$ low or -5 V , their function is controlled by HBEN (see Table I). |
| 17 | $\mathrm{V}_{\mathrm{DD}}$ | Positive Supply, $+5 \mathrm{~V} \pm 5 \%$. |
| 18 | AGND | Analog Ground. Ground reference for track/hold, reference and DAC. |
| 19 | REF OUT | Voltage Reference Output. The internal 3 V reference is provided at this pin. The external load capability is $500 \mu \mathrm{~A}$. |
| 20 | $\mathrm{V}_{\text {IN }}$ | Analog Input. The analog input range is $\pm 3 \mathrm{~V}$ for the AD7870, $\pm 10 \mathrm{~V}$ for the AD7876 and 0 to +5 V for the AD7875. |
| 21 | $\mathrm{V}_{\text {Ss }}$ | Negative Supply, $-5 \mathrm{~V} \pm 5 \%$. |
| 22 | 12/8/CLK | Three Function Input. Defines the data format and serial clock format. With this pin at +5 V , the output data format is 12 -bit parallel only. With this pin at 0 V , either byte or serial data is available and SCLK is not continuous. With this pin at -5 V , byte or serial data is again available but SCLK is now continuous. |
| 23 | CONVST | Convert Start. A low to high transition on this input puts the track/hold into its hold mode and starts conversion. This input is asynchronous to the CLK input. |
| 24 | $\overline{\text { CS }}$ | Chip Select. Active low logic input. The device is selected when this input is active. With CONVST tied low, a new conversion is initiated when CS goes low. |


| HBEN | DB7/LOW | DB6/LOW | DB5/LOW | DB4/LOW | DB3/DB11 | DB2/DB10 | DB1/DB9 | DB0/DB8 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| HIGH | LOW | LOW | LOW | LOW | DB11 (MSB) | DB10 | DB9 | DB8 |
| LOW | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 (LSB) |

Table I. Output Data for Byte Interfacing
PIN CONFIGURATIONS ${ }^{1}$



## FEATURES

Complete Monolithic 14-Bit ADC
2s Complement Coding
Parallel, Byte and Serial Digital Interface
$\mathbf{8 0} \mathbf{~ d B}$ SNR at $10 \mathbf{k H z}$ Input Frequency
57 ns Data Access Time
Low Power-50 mW typ
83 kSPS Throughput Rate
16-Lead SOIC (AD7872)

## APPLICATIONS

Digital Signal Processing
High Speed Modems
Speech Recognition and Synthesis
Spectrum Analysis
DSP Servo Control

## GENERAL DESCRIPTION

The AD7871 and AD7872 are fast, complete, 14-bit analog-todigital converters. They consist of a track/hold amplifier, successive-approximation ADC, 3 V buried Zener reference and versatile interface logic. The ADC features a self-contained, laser trimmed internal clock, so no external clock timing components are required. The on-chip clock may be overridden to synchronize ADC operation to the digital system for minimum noise.

The AD7871 offers a choice of three data output formats: a single, parallel, 14 -bit word; two 8 -bit bytes or a 14 -bit serial data stream. The AD7872 is a serial output device only. The two parts are capable of interfacing to all modern microprocessors and digital signal processors.
The AD7871 and AD7872 operate from $\pm 5$ V power supplies, accept bipolar input signals of $\pm 3 \mathrm{~V}$ and can convert full power signals up to 41.5 kHz .
In addition to the traditional dc accuracy specifications, the AD7871 and AD7872 are also fully specified for dynamic performance parameters including distortion and signal-to-noise ratio.
Both devices are fabricated in Analog Devices' LC ${ }^{2}$ MOS mixed technology process. The AD7871 is available in 28-pin plastic DIP, hermetic DIP and PLCC packages. The AD7872 is available in 16-pin plastic and hermetic DIP packages or 16-lead SOIC.

FUNCTIONAL BLOCK DIAGRAMS


## PRODUCT HIGHLIGHTS

1. Complete 14 -Bit ADC on a Chip.
2. Dynamic Specifications for DSP Users.
3. Low Power.

| Parameter | J, A Versions ${ }^{1}$ | $\begin{array}{\|l} \hline \mathbf{K}, \mathbf{B} \\ \text { Versions } \end{array}$ | $\begin{aligned} & \text { T } \\ & \text { Version }{ }^{1} \end{aligned}$ | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DYNAMIC PERFORMANCE ${ }^{2}$ <br> Signal to Noise Ratio ${ }^{3}$ (SNR) @ $+25^{\circ} \mathrm{C}$ $T_{\text {min }}$ to $T_{\text {max }}$ <br> Total Harmonic Distortion (THD) <br> Peak Harmonic or Spurious Noise <br> Intermodulation Distortion (IMD) Second Order Terms <br> Third Order Terms <br> Track/Hold Acquisition Time | $\begin{aligned} & 80 \\ & 80 \\ & -86 \\ & -86 \\ & -86 \\ & -86 \end{aligned}$ | 80 <br> 80 <br> $-90$ <br> $-90$ <br> $-90$ <br> $-90$ | $\begin{aligned} & 79 \\ & 79 \\ & -85 \\ & -85 \\ & -85 \\ & -85 \\ & 2 \end{aligned}$ | dB min dB min dB max dB typ dB max dB typ dB max dB typ dB max dB typ $\mu \mathrm{S}$ max | $\mathrm{V}_{\mathrm{IN}}=10 \mathrm{kHz}$ Sine Wave SNR is Typically 82 dB for $<\mathrm{V}_{\text {IN }}<41.5 \mathrm{kHz}$; $\mathrm{V}_{\text {IN }}=10 \mathrm{kHz}$ Sine Wave; $\mathrm{V}_{\mathrm{IN}}=10 \mathrm{kHz}$. $\begin{aligned} & \mathrm{fa}=9 \mathrm{kHz}, \mathrm{fb}=9.5 \mathrm{kHz}, \mathrm{f}_{\text {SAMPLE }}=50 \mathrm{kHz} \\ & \mathrm{fa}=9 \mathrm{kHz}, \mathrm{fb}=9.5 \mathrm{kHz}, \mathrm{f}_{\text {SAMPLE }}=50 \mathrm{kHz} \end{aligned}$ |
| DC ACCURACY <br> Resolution <br> Minimum Resolution for Which <br> No Missing Codes Are Guaranteed <br> Integral Nonlinearity @ $+25^{\circ} \mathrm{C}$ <br> Integral Nonlinearity <br> Bipolar Zero Error <br> Positive Gain Error ${ }^{4}$ <br> Negative Gain Error ${ }^{4}$ | $\begin{gathered} 14 \\ 14 \\ \\ \pm 12 \\ \pm 12 \\ \pm 12 \end{gathered}$ | 14 $\begin{aligned} & 14 \\ & \pm 1 / 2 \\ & \pm 1 \\ & \pm 12 \\ & \pm 12 \\ & \pm 12 \end{aligned}$ | $\begin{aligned} & 14 \\ & 14 \\ & \pm 1 / 2 \\ & \pm 1 \\ & \pm 12 \\ & \pm 12 \\ & \pm 12 \end{aligned}$ | $\begin{aligned} & \text { Bits } \\ & \text { Bits } \\ & \text { LSB typ } \\ & \text { LSB max } \\ & \text { LSB max } \\ & \text { LSB max } \\ & \text { LSB max } \end{aligned}$ |  |
| ANALOG INPUT Input Voltage Range Input Current | $\begin{array}{\|l}  \pm 3 \\ \pm 500 \end{array}$ | $\begin{aligned} & \pm 3 \\ & \pm 500 \end{aligned}$ | $\begin{aligned} & \pm 3 \\ & \pm 500 \end{aligned}$ | Volts <br> $\mu \mathrm{A}$ max |  |
| REFERENCE OUTPUT <br> REF OUT @ $+25^{\circ} \mathrm{C}$ <br> $T_{\text {min }}$ to $T_{\text {max }}$ <br> REF OUT Tempco <br> Reference Load Sensitivity <br> ( $\Delta$ REF OUT/ $\Delta \mathrm{I}$ ) | $\left\lvert\, \begin{array}{cc} 2.99 / 3.01 \\ 2.98 / 3.02 \\ & \\ \pm 1 & \ldots \end{array}\right.$ | $\begin{aligned} & 2.99 / 3.01 \\ & 2.98 / 3.02 \\ & \pm 40 \\ & \\ & \pm 1 \end{aligned}$ | $\left\lvert\, \begin{aligned} & 2.99 / 3.01 \\ & 2.98 / 3.02 \\ & \pm 40 \\ & \\ & \pm 1 \end{aligned}\right.$ | $V \min / V \max$ $\mathrm{V} \min / \mathrm{V}$ max $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ max $m V$ max | Typically 35 ppm <br> Reference Load Current Change ( $0-500 \mu \mathrm{~A}$ ); <br> Reference Load Should Not Be Changed During Conversion |
| LOGIC INPUTS <br> Input High Voltage, $\mathrm{V}_{\text {INH }}$ Input Low Voltage, $\mathrm{V}_{\text {INL }}$ Input Current, $\mathrm{I}_{\mathrm{IN}}$ Input Current (14/8/CLK Input Only) Input Capacitance, $\mathrm{C}_{\mathrm{IN}}{ }^{5}$ | $\begin{array}{\|l} 2.4 \\ 0.8 \\ \pm 10 \\ \pm 10 \\ 10 \end{array}$ | $\begin{array}{\|l} 2.4 \\ 0.8 \\ \pm 10 \\ \pm 10 \\ 10 \end{array}$ | $\begin{array}{\|l} 2.4 \\ 0.8 \\ \pm 10 \\ \pm 10 \\ 10 \end{array}$ | V min V max $\mu \mathrm{A}$ max $\mu \mathrm{A}$ max pF max | $\begin{aligned} & V_{D D}=5 \mathrm{~V} \pm 5 \% \\ & \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \% \\ & \mathrm{~V}_{\text {IN }}=0 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{DD}} \\ & \mathrm{~V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{Ss}} \text { to } \mathrm{V}_{\mathrm{DD}} \end{aligned}$ |
| LOGIC OUTPUTS <br> Output High Voltage, $\mathrm{V}_{\mathrm{OH}}$ Output Low Voltage, $\mathrm{V}_{\mathrm{OL}}$ DB13 - DB0 <br> Floating-State Leakage Current Floating-State Output Capacitance ${ }^{5}$ | $\begin{aligned} & 4.0 \\ & 0.4 \\ & 10 \\ & 15 \end{aligned}$ | $\left\lvert\, \begin{gathered} 4.0 \\ 0.4 \\ \vdots \\ 10 \\ 15 \end{gathered}\right.$ | $\begin{aligned} & 4.0 \\ & 0.4 \\ & 10 \\ & 15 \end{aligned}$ | $V$ min <br> V max <br> $\mu \mathrm{A}$ max <br> pF max | $\begin{aligned} & \mathrm{I}_{\text {SOURCE }}=40 \mu \mathrm{~A} \\ & \mathrm{I}_{\text {SINK }}=1.6 \mathrm{~mA} \end{aligned}$ |
| CONVERSION TIME <br> External Clock <br> Internal Clock | $\begin{array}{\|l\|} \hline 10 \\ 10.5 \\ \hline \end{array}$ | $\begin{array}{\|l\|} \hline 10 \\ 10.5 \end{array}$ | $\begin{array}{\|l\|} \hline 10 \\ 10.5 \end{array}$ | $\mu \mathrm{s}$ max $\mu \mathrm{s}$ max | The Internal Clock Has a Nominal Value of 2 MHz |
| POWER REQUIREMENTS <br> $V_{D D}$ <br> $V_{s s}$ <br> $I_{D D}$ <br> $\mathrm{I}_{\mathrm{ss}}$ <br> Power Dissipation | $\begin{aligned} & +5 \\ & -5 \\ & 13 \\ & 6 \\ & 95 \end{aligned}$ | $\begin{array}{\|l} +5 \\ -5 \\ 13 \\ 6 \\ 95 \end{array}$ | $\begin{aligned} & +5 \\ & -5 \\ & 13 \\ & 6 \\ & 95 \end{aligned}$ | V nom <br> V nom mA max mA max mW max | $\pm 5 \%$ for Specified Performance <br> $\pm 5 \%$ for Specified Performance <br> Typically 6 mA <br> Typically 4 mA <br> Typically 50 mW |

[^48]TIMING CHARACTERISTICS ${ }^{1,2}\left(V_{D D}=+5 \mathrm{~V} \pm 5 \%, V_{S S}=-5 \mathrm{~V} \pm 5 \%\right.$, AGND $=\operatorname{DGND}=0 \mathrm{~V}$. See Figures $3,4,5$ and 6 . $)$

| Parameter | Limit at $\mathbf{T}_{\text {min }}, \mathbf{T}_{\text {max }}$ (J, K, A, B Versions) | Limit at $\mathrm{T}_{\text {min }}, \mathrm{T}_{\text {max }}$ (T Version) | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{1}$ | 50 | 50 | ns min | CONVST Pulse Width |
| $\mathrm{t}_{2}$ | 0 | 0 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{RD}}$ Setup Time (Mode 1) |
| $\mathrm{t}_{3}$ | 60 | 75 | ns min | $\overline{\mathrm{RD}}$ Pulse Width |
| $\mathrm{t}_{4}$ | 0 | 0 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{RD}}$ Hold Time (Mode 1) |
| $\mathrm{t}_{5}$ | 70 | 70 | ns min | $\overline{\mathrm{RD}}$ to INT Delay |
| $t_{6}{ }^{3}$ | 57 | 70 | ns max | Data Access Time after $\overline{\mathrm{RD}}$ |
| $\mathrm{t}_{7}{ }^{4}$ | 5 | 5 | $n s \min$ | Bus Relinquish Time after $\overline{\mathrm{RD}}$ |
|  | 50 | 50 | ns max |  |
| $\mathrm{t}_{8}$ | 0 | 0 | ns min | HBEN to $\overline{\mathrm{RD}}$ Setup Time |
| $\mathrm{t}_{9}$ | 0 | 0 | ns min | HBEN to RD Hold Time |
|  | 100 | 100 | ns min | SSTRB to SCLK Falling Edge Setup Time |
| $\mathrm{t}_{11}{ }^{5}$ | 440 | 440 | ns min | SCLK Cycle Time |
| $\mathrm{t}_{12}{ }^{6}$ | 155 | 155 | ns max | SCLK to Valid Data Delay. $\mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}$ |
| $\mathrm{t}_{13}$ | 140 | 150 | ns max | SCLK Rising Edge to SSTRB |
|  | 20 | 20 | ns min |  |
| $\mathrm{t}_{14}$ | 4 | 4 | ns min | Bus Relinquish Time after SCLK |
|  | 100 | 100 | ns max |  |
| $\mathrm{t}_{15}$ | 60 | 60 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{RD}}$ Setup Time (Mode 2) |
| $\mathrm{t}_{16}$ | 120 | 120 | ns max | CS to BUSY Propagation Delay |
| $\mathrm{t}_{17}{ }^{3}$ | 200 | 200 | ns min | Data Setup Time Prior to BUSY |
| $\mathrm{t}_{18}$ | 0 | 0 | $n s$ min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{RD}}$ Hold Time (Mode 2) |
| $\mathrm{t}_{19}$ | 0 | 0 | ns min | HBEN to CS Setup Time |
| $\mathrm{t}_{20}$ | 0 | 0 | ns min | HBEN to CS Hold Time |

NOTES
${ }^{1}$ Timing Specifications in bold print are $100 \%$ production tested. All other times are sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance. All input signals are specified with $\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}$ ( $10 \%$ to $90 \%$ of 5 V ) and timed from a voltage level of 1.6 V .
${ }^{2}$ Serial timing is measured with a $4.7 \mathrm{k} \Omega$ pull-up resistor on SDATA and $\overline{\text { SSTRB }}$ and a $2 \mathrm{k} \Omega$ pull-up resistor on SCLK. The capacitance on all three outputs is 35 pF .
${ }^{3} t_{6}$ and $t_{17}$ are measured with the load circuits of Figure 1 and defined as the time required for an output to cross 0.8 V or 2.4 V .
${ }^{{ }^{t_{7}}}$ is derived from the measured time taken by the data outputs to change 0.5 V when loaded with the circuit of Figure 2 . The measured number is then extrapolated back to remove
the effects of charging or discharging the 50 pF capacitor. This means that the time, $\mathrm{t}_{7}$, quoted in the Timing Characteristics is the true bus relinquish time of the part and is
independent of bus loading.
${ }^{5}$ SCLK mark/space ratio (measured from a voltage level of 1.6 V ) is $40 / 60$ to $60 / 40$.
${ }^{6}$ SDATA will drive higher capacitive loads, but this will add to $t_{12}$ since it increases the external RC time constant $\left(4.7 \mathrm{k} \Omega / / \mathrm{C}_{\mathrm{L}}\right)$ and hence the time to reach 2.4 V . Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS*

| $\mathrm{V}_{\text {DD }}$ to AGND | $-7$ |
| :---: | :---: |
| $\mathrm{V}_{\text {ss }}$ to AGND | - to -7 V |
| AGND to DGND . . . . . . . . . . . . - | -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| $\mathrm{V}_{\text {IN }}$ to AGND . . . . . . . . . . . $\mathrm{V}_{\text {Ss }}$ - | -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| REF OUT, $\mathrm{C}_{\text {REF }}$ to AGND | 0 V to $\mathrm{V}_{\mathrm{DD}}$ |
| Digital Inputs to DGND . . . . . . . . - | -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| Digital Outputs to DGND . . . . . . . - | -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| Operating Temperature Range |  |
| Commercial (J, K Versions) | to $+70^{\circ} \mathrm{C}$ |
| Industrial (A, B Versions) | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Extended (T Version) | $55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Lead Temperature (Soldering, 10 secs) | $+300^{\circ} \mathrm{C}$ |
| ower Dissipation (Any Package) to $+75^{\circ} \mathrm{C}$ | $5^{\circ} \mathrm{C}$. . . . . . 450 mW |
| Derates above $+75^{\circ} \mathrm{C}$ by | $6 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ |

*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.


Figure 1. Load Circuit for Access Time


Figure 2. Load Circuit for Output Float Delay

## CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are inserted.


DIP


DIP, SOIC


PLCC


AD7871 ORDERING GUIDE

| Model $\mathbf{l}^{1,2}$ | Temperature <br> Range | SNR | Relative <br> Accuracy | Package <br> Option ${ }^{3}$ |
| :--- | :--- | :--- | :--- | :--- |
| AD7871JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $80 \mathrm{dBs} \min$ |  | $\mathrm{N}-28$ |
| AD7871KN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $80 \mathrm{dBs} \min$ | $\pm 1 \max$ | $\mathrm{~N}-28$ |
| AD7871JP | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $80 \mathrm{dBs} \min$ |  | $\mathrm{P}-28 \mathrm{~A}$ |
| AD7871KP | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $80 \mathrm{dBs} \min$ | $\pm 1 \max$ | $\mathrm{P}-28 \mathrm{~A}$ |
| AD7871AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $80 \mathrm{dBs} \min$ |  | $\mathrm{Q}-28$ |
| AD7871BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $80 \mathrm{dBs} \min$ | $\pm 1 \max$ | $\mathrm{Q}-28$ |
| AD7871TQ ${ }^{4}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $79 \mathrm{dBs} \min$ | $\pm 1 \max$ | $\mathrm{Q}-28$ |

NOTES
${ }^{1}$ To order MIL-STD-883, Class B, processed parts, add /883B to part number. Contact local sales office for military data sheet.
${ }^{2}$ Contact local sales office for LCCC availability.
${ }^{3} \mathrm{~N}=$ Plastic DIP; $\mathrm{P}=$ Plastic Leaded Chip Carrier (PLCC); $\mathrm{Q}=$ Cerdip.
For outline information see Package Information section.
${ }^{4}$ Available to $/ 883$ B processing only.
AD7872 ORDERING GUIDE

| Model $^{1}$ | Temperature <br> Range | SNR | Relative <br> Accuracy | Package <br> Option |
| :--- | :--- | :--- | :--- | :--- |
| AD7872AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $80 \mathrm{dBs} \min$ |  | $\mathrm{N}-16$ |
| AD7872JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 80 dBs min |  | $\mathrm{N}-16$ |
| AD7872KN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $80 \mathrm{dBs} \min$ | $\pm 1 \max$ | $\mathrm{~N}-16$ |
| AD7872JR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 80 dBs min |  | $\mathrm{R}-16$ |
| AD7872KR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 80 dBs min | $\pm 1 \max$ | $\mathrm{R}-16$ |
| AD7872AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $80 \mathrm{dBs} \min$ |  | $\mathrm{Q}-16$ |
| AD7872BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $80 \mathrm{dBs} \min$ | $\pm 1 \max$ | $\mathrm{Q}-16$ |
| AD7872TQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 79 dBs min | $\pm 1 \max$ | $\mathrm{Q}-16$ |

## NOTES

${ }^{1}$ To order MLL-STD-883, Class B, processed parts, add /883B to part
number. Contact local sales office for military data sheet.
${ }^{2} \mathrm{~N}=$ Plastic DIP; $\mathrm{Q}=$ Cerdip; $\mathrm{R}=$ Small Outline IC (SOIC). For outline information see Package Information section.
${ }^{3}$ Available to $/ 883 \mathrm{~B}$ processing only.


Figure 3. Mode 1 Timing Diagram, 14-Bit Parallel Read


Figure 4. Mode 1 Timing Diagram, Byte or Serial Read


Figure 5. Mode 2 Timing Diagram, 14-Bit Parallel Read


NOTES
TTIMES $t_{51}, t_{12}, t_{15}$ AND $t_{20}$ ARE THE SAME FOR A HIGH BYTE READ AS FOR A LOW BYTE READ
CONTINUOUS SCLK (DASHED LINE) WHEN 14/ $\overline{8} /$ CLK (CONTROL) $=-5$ V; NONCONTINUOUS WHEN
CONTINUOUS SCLK (DASHED LNE) WHEN $14 / \overline{8} / C L K$ (CONTROL)
$14 / 8 / C L K ~(C O N T R O L) ~$
$=0$
Figure 6. Mode 2 Timing Diagram, Byte or Serial Read

## FEATURES

Four On-Chip Track/Hold Amplifiers<br>Simultaneous Sampling of 4 Channels<br>Fast 12-Bit ADC with $8 \mu$ s Conversion Time/Channel 29 kHz Sample Rate for All Four Channels<br>On-Chip Reference<br>$\pm 10 \mathrm{~V}$ Input Range<br>$\pm 5 \mathrm{~V}$ Supplies<br>APPLICATIONS<br>Sonar<br>Motor Controllers<br>Adaptive Filters<br>Digital Signal Processing

## GENERAL DESCRIPTION

The AD7874 is a four-channel simultaneous sampling, 12-bit data acquisition system. The part contains a high speed 12-bit ADC, on-chip reference, on-chip clock and four track/hold amplifiers. This latter feature allows the four input channels to be sampled simultaneously, thus preserving the relative phase information of the four input channels, which is not possible if all four channels share a single track/hold amplifier. This makes the AD7874 ideal for applications such as phased-array sonar and ac motor controllers where the relative phase information is important.
The aperture delay of the four track/hold amplifiers is small and specified with minimum and maximum limits. This allows several AD7874s to sample multiple input channels simultaneously without incurring phase errors between signals connected to several devices. A reference output/reference input facility also allows several AD7874s to be driven from the same reference source.

In addition to the traditional dc accuracy specifications such as linearity, full-scale and offset errors, the AD7874 is also fully specified for dynamic performance parameters including distortion and signal-to-noise ratio.
The AD7874 is fabricated in Analog Devices' Linear Compatible CMOS (LC ${ }^{2}$ MOS) process, a mixed technology process that combines precision bipolar circuits with low-power CMOS logic. The part is available in a 28 -pin, $0.6^{\prime \prime}$ wide, plastic or hermetic dual-in-line package (DIP), in a 28 -terminal leadless ceramic chip carrier (LCCC) and in a 28 -pin SOIC.

FUNCTIONAL BLOCK DIAGRAM


## PRODUCT HIGHLIGHTS

1. Simultaneous Sampling of Four Input Channels: Four input channels, each with its own track/hold amplifier, allow simultaneous sampling of input signals. Track/hold acquisition time is $2 \mu \mathrm{~s}$, and the conversion time per channel is $8 \mu \mathrm{~s}$, allowing 29 kHz sample rate for all four channels.
2. Tight Aperture Delay Matching.

The aperture delay for each channel is small and the aperture delay matching between the four channels is less than 4 ns . Additionally, the aperture delay specification has upper and lower limits allowing multiple AD7874s to sample more than four channels.
3. Fast Microprocessor Interface.

The high speed digital interface of the AD7874 allows direct connection to all modern 16 -bit microprocessors and digital signal processors.

# AD7874 <br> -SPECIFICATIONS $\left(\mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=-5 \mathrm{~V}\right.$, AGND $=\mathrm{DGND}=0 \mathrm{~V}$, REF IN $=+3 \mathrm{~V}, \mathrm{f}_{\mathrm{CLK}}=2.5 \mathrm{MHz}$ external. All specifications $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ unless otherwise noted.) 

| Parameter | A Version | B Version | S Version | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| SAMPLE-AND-HOLD <br> Acquisition Time ${ }^{2}$ to $\mathbf{0 . 0 1 \%}$ <br> Droop Rate ${ }^{2,3}$ <br> -3 dB Small Signal Bandwidth ${ }^{3}$ <br> Aperture Delay ${ }^{2}$ <br> Aperture Jitter ${ }^{2,3}$ <br> Aperture Delay Matching ${ }^{2}$ | $\begin{aligned} & 2 \\ & 1 \\ & 500 \\ & 0 \\ & 40 \\ & 200 \\ & 4 \end{aligned}$ | $\begin{aligned} & 2 \\ & 1 \\ & 500 \\ & 0 \\ & 40 \\ & 200 \\ & 4 \end{aligned}$ | $\begin{aligned} & 2 \\ & 2 \\ & 500 \\ & 0 \\ & 40 \\ & 200 \\ & 4 \end{aligned}$ | $\mu \mathrm{s}$ max $\mathrm{mV} / \mathrm{ms}$ max kHz typ ns min ns max ps typ ns max | $\mathrm{V}_{\mathrm{IN}}=500 \mathrm{mV} \mathrm{p}-\mathrm{p}$ |
| SAMPLE-AND-HOLD AND ADC DYNAMIC PERFORMANCE Signal-to-Noise Ratio Total Harmonic Distortion Peak Harmonic or Spurious Noise Intermodulation Distortion 2nd Order Terms 3rd Order Terms Channel-to-Channel Isolation ${ }^{2}$ | $\begin{aligned} & 70 \\ & -78 \\ & -78 \\ & -80 \\ & -80 \\ & -80 \\ & -80 \end{aligned}$ | $\left\lvert\, \begin{aligned} & 71 \\ & -80 \\ & -80 \\ & \\ & -80 \\ & -80 \\ & -80 \end{aligned}\right.$ | $\begin{aligned} & 70 \\ & -78 \\ & -78 \\ & -80 \\ & -80 \\ & -80 \\ & -80 \end{aligned}$ | dB min dB max dB max <br> dB max dB max dB max | $\begin{aligned} & \mathrm{f}_{\text {IN }}=10 \mathrm{kHz} \text { Sine Wave, } \mathrm{f}_{\text {SAMPLE }}=29 \mathrm{kHz} \\ & \mathrm{f}_{\text {IN }}=10 \mathrm{kHz} \text { Sine Wave, } \mathrm{f}_{\text {SAMPLE }}=29 \mathrm{kHz} \\ & \mathrm{f}_{\text {IN }}=10 \mathrm{kHz} \text { Sine Wave, } \mathrm{f}_{\text {SAMPLE }}=29 \mathrm{kHz} \\ & \mathrm{fa}^{2}=9 \mathrm{kHz}, \mathrm{fb}=9.5 \mathrm{kHz}, \mathrm{f}_{\text {SAMPLE }}=29 \mathrm{kHz} \end{aligned}$ |
| DC ACCURACY <br> Resolution <br> Relative Accuracy Differential Nonlinearity Positive Full-Scale Error ${ }^{4}$ Negative Full-Scale Error ${ }^{4}$ Full-Scale Error Match Bipolar Zero Error Bipolar Zero Error Match | $\begin{aligned} & 12 \\ & \pm 1 \\ & \pm 1 \\ & \pm 5 \\ & \pm 5 \\ & 5 \\ & \pm 5 \\ & 4 \end{aligned}$ | $\begin{aligned} & 12 \\ & \pm 1 / 2 \\ & \pm 1 \\ & \pm 5 \\ & \pm 5 \\ & 5 \\ & \pm 5 \\ & 4 \end{aligned}$ | $\begin{aligned} & 12 \\ & \pm 1 \\ & \pm 1 \\ & \pm 5 \\ & \pm 5 \\ & 5 \\ & \pm 5 \\ & 4 \end{aligned}$ | Bits <br> LSB max <br> LSB max <br> LSB max <br> LSB max <br> LSB max <br> LSB max <br> LSB max | No Missing Codes Guaranteed <br> Any Channel <br> Any Channel <br> Between Channels <br> Any Channel <br> Between Channels |
| ANALOG INPUTS Input Voltage Range Input Current | $\begin{aligned} & \pm 10 \\ & \pm 600 \end{aligned}$ | $\begin{array}{\|l}  \pm 10 \\ \pm 600 \end{array}$ | $\begin{aligned} & \pm 10 \\ & \pm 600 \end{aligned}$ | Volts $\mu \mathrm{A}$ max |  |
| ```REFERENCE OUTPUT \({ }^{5}\) REF OUT REF OUT Error @ \(+25^{\circ} \mathrm{C}\) \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) REF OUT Temperature Coefficient Reference Load Change``` | $\begin{aligned} & 3 \\ & \pm 0.33 \\ & \pm 1 \\ & \pm 35 \\ & \pm 1 \end{aligned}$ | $\begin{aligned} & 3 \\ & \pm 0.33 \\ & \pm 1 \\ & \pm 35 \\ & \pm 1 \end{aligned}$ | $\begin{aligned} & 3 \\ & \pm 0.33 \\ & \pm 1 \\ & \pm 35 \\ & \pm 2 \end{aligned}$ | V nom <br> \% max <br> $\%$ max <br> $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ typ <br> $m V$ max | Reference Load Current Change ( $0-500 \mu \mathrm{~A}$ ) <br> Reference Load Should Not Be Changed During Conversion |
| REFERENCE INPUT <br> Input Voltage Range Input Current Input Capacitance ${ }^{3}$ | $\begin{aligned} & 2.85 / 3.15 \\ & \pm 1 \\ & 10 \end{aligned}$ | $\begin{aligned} & 2.85 / 3.15 \\ & \pm 1 \\ & 10 \end{aligned}$ | $\begin{aligned} & 2.85 / 3.15 \\ & \pm 1 \\ & 10 \end{aligned}$ | $\mathrm{V} \min / \mathrm{V}$ max $\mu \mathrm{A}$ max pF max | $3 \mathrm{~V} \pm 5 \%$ |
| LOGIC INPUTS <br> Input High Voltage, $\mathrm{V}_{\text {INH }}$ Input Low Voltage, $\mathrm{V}_{\text {INL }}$ Input Current, $\mathrm{I}_{\text {IN }}$ Input Capacitance, $\mathrm{C}_{\text {IN }}{ }^{3}$ | $\begin{aligned} & 2.4 \\ & 0.8 \\ & \pm 10 \\ & 10 \end{aligned}$ | $\begin{array}{\|l} 2.4 \\ 0.8 \\ \pm 10 \\ 10 \end{array}$ | $\begin{array}{\|l} 2.4 \\ 0.8 \\ \pm 10 \\ 10 \end{array}$ | $V$ min V max $\mu$ A max pF max | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \% \\ & \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \% \\ & \mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{DD}} \end{aligned}$ |
| LOGIC OUTPUTS <br> Output High Voltage, $\mathrm{V}_{\mathrm{OH}}$ <br> Output Low Voltage, $\mathrm{V}_{\text {OL }}$ <br> DB0-DB11 <br> Floating-State Leakage Current Floating-State Output Capacitance Output Coding | $\begin{array}{ll} 4.0 & \\ 0.4 & \\ \pm 10 & \\ 10 & \\ & 2 \mathrm{~s} \mathrm{Cc} \end{array}$ | $\begin{array}{\|l\|} \hline 4.0 \\ 0.4 \\ \\ \pm 10 \\ 10 \\ \text { OMPLEME } \end{array}$ | $\begin{aligned} & 4.0 \\ & 0.4 \\ & \pm 10 \\ & 10 \\ & \text { NT } \end{aligned}$ | $V$ min V max $\mu \mathrm{A}$ max pF max | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \% ; \mathrm{I}_{\text {SOURCE }}=40 \mu \mathrm{~A} \\ & \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \% ; \mathrm{I}_{\text {SINK }}=1.6 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{DD}} \end{aligned}$ |
|  | $\begin{aligned} & +5 \\ & -5 \\ & 18 \\ & 12 \\ & 150 \\ & \hline \end{aligned}$ | $\begin{aligned} & +5 \\ & -5 \\ & 18 \\ & 12 \\ & 150 \end{aligned}$ | $\begin{aligned} & +5 \\ & -5 \\ & 18 \\ & 12 \\ & 150 \\ & \hline \end{aligned}$ | V nom V nom mA max mA max mW max | $\pm 5 \%$ for Specified Performance <br> $\pm 5 \%$ for Specified Performance $\begin{aligned} & \overline{\mathrm{CS}}=\overline{\mathrm{RD}}=\overline{\mathrm{CONVST}}=+5 \mathrm{~V} ; \text { Typically } 12 \mathrm{~mA} \\ & \overline{\mathrm{CS}}=\overline{\mathrm{RD}}=\overline{\mathrm{CONVST}}=+5 \mathrm{~V} ; \text { Typically } 8 \mathrm{~mA} \\ & \overline{\mathrm{CS}}=\overline{\mathrm{RD}}=\overline{\text { CONVST }}=+5 \mathrm{~V} ; \text { Typically } 100 \mathrm{~mW} \end{aligned}$ |

[^49]

| Parameter | A, B Versions | S Version | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{1}$ | 50 | 50 | ns min | CONVST Pulse Width |
| $\mathrm{t}_{2}$ | 0 | 0 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{RD}}$ Setup Time |
| $\mathrm{t}_{3}$ | 60 | 70 | ns min | $\overline{\mathrm{RD}}$ Pulse Width |
| $\mathrm{t}_{4}$ | 0 | 0 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{RD}}$ Hold Time |
| $\mathrm{t}_{5}$ | 60 | 60 | ns max | $\overline{\mathrm{RD}}$ to $\overline{\mathrm{INT}}$ Delay |
| $\mathrm{t}_{6}{ }^{2}$ | 57 | 70 | ns max | Data Access Time after $\overline{\mathrm{RD}}$ |
| $\mathrm{t}_{7}{ }^{3}$ | 5 | 5 | ns min | Bus Relinquish Time after $\overline{\mathrm{RD}}$ |
|  | 45 | 50 | ns max |  |
| $\mathrm{t}_{8}$ | 130 | 150 | ns min | Delay Time between Reads |
| $\mathrm{t}_{\text {conv }}$ | 31 | 31 | $\mu \mathrm{s}$ min | $\overline{\text { CONVST }}$ to INT, External Clock |
|  | 32.5 | 32.5 | $\mu \mathrm{s}$ max | CONVST to INT, External Clock |
|  | 31 | 31 | $\mu s \mathrm{~min}$ | CONVST to INT, Internal Clock |
|  | 35 | 35 | $\mu \mathrm{s}$ max | $\overline{\text { CONVST }}$ to $\overline{\text { INT, Internal Clock }}$ |
| $\mathrm{t}_{\text {cLK }}$ | 10 | 10 | $\mu \mathrm{S}$ max | Minimum Input Clock Period |

NOTES
${ }^{1}$ Timing Specifications in bold print are $100 \%$ production tested. All other times are sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance. All input signals are specified with $\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of $+5 \mathrm{~V})$ and timed from a voltage level of 1.6 V .
${ }^{2} \mathrm{t}_{6}$ is measured with the load circuit of Figure 1 and defined as the time required for an output to cross 0.8 V or 2.4 V .
${ }^{3} \mathrm{t}_{7}$ is derived from the measured time taken by the data outputs to change 0.5 V when loaded with the circuit of Figure 2 . The measured number is then extrap, olated back to remove the effects of charging or discharging the 50 pF capacitor. This means that the time, $\mathrm{t}_{7}$, quoted in the timing characteristics is the true bus relinquish time of the part and as such is independent of external bus loading capacitances.
Specifications subject to change without notice.


Figure 1. Load Circuit for Access Time


Figure 2. Load Circuit for Bus Relinquish Time

## ABSOLUTE MAXIMUM RATINGS*

( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)
$\mathrm{V}_{\mathrm{DD}}$ to AGND . . . . . . . . . . . . . . . . . . . -0.3 V to +7 V
$\mathrm{V}_{\mathrm{DD}}$ to DGND . . . . . . . . . . . . . . . . . . . . -0.3 V to +7 V
$\mathrm{V}_{\text {SS }}$ to AGND . . . . . . . . . . . . . . . . . . . . . +0.3 V to -7 V
AGND to DGND . . . . . . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
$\mathrm{V}_{\text {IN }}$ to AGND . . . . . . . . . . . . . . . . . . . . . -15 V to +15 V
REF OUT to AGND . . . . . . . . . . . . . . . . . . . 0 V to $\mathrm{V}_{\mathrm{DD}}$
Digital Inputs to DGND . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Digital Outputs to DGND . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Operating Temperature Range
Commercial (A, B Versions) . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Extended (S Version) . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 secs) . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Power Dissipation (Any Package) to $+75^{\circ} \mathrm{C}$. . . . . $1,000 \mathrm{~mW}$
Derates above $+75^{\circ} \mathrm{C}$ by . . . . . . . . . . . . . . . . . . $10 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are inserted.

ORDERING GUIDE

|  | Temperature <br> Range | SNR <br> (dBs) | Relative <br> Accuracy <br> (LSB) | Package <br> Option |
| :--- | :--- | :--- | :--- | :--- |
| AD7874AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 70 min | $\pm 1 \max$ | $\mathrm{~N}-28$ |
| AD7874BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 72 min | $\pm 1 / 2 \max$ | $\mathrm{~N}-28$ |
| AD7874AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 70 min | $\pm 1 \max$ | $\mathrm{R}-28$ |
| AD7874BR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 72 min | $\pm 1 / 2 \max$ | $\mathrm{R}-28$ |
| AD7874AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $70 \min$ | $\pm 1 \max$ | $\mathrm{Q}-28$ |
| AD7874BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 72 min | $\pm 1 / 2 \max$ | $\mathrm{Q}-28$ |
| AD7874SQ ${ }^{3}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 70 min | $\pm 1 \max$ | $\mathrm{Q}-28$ |
| AD7874SE ${ }^{3}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 70 min | $\pm 1 \max$ | $\mathrm{E}-28 \mathrm{~A}$ |

NOTES
${ }^{1}$ To order MIL-STD-883, Class B processed parts, add /883B to part number.
Contact our local sales office for military data sheet and availability.
${ }^{2} \mathrm{E}=$ Leaded Ceramic Chip Carrier; $\mathrm{N}=$ Plastic DIP; $\mathrm{Q}=$ Cerdip; $\mathrm{R}=$ SOIC.
For outline information see Package Information section.
${ }^{3}$ Available to $/ 883 \mathrm{~B}$ processing only.

## PIN CONFIGURATIONS

## DIP and SOIC



TIMES $t_{2}, t_{3}, t_{4}, t_{6}, t_{7}$ AND $t_{8}$ ARE THE SAME FOR ALL FOUR READ OPERATIONS.
Figure 7. AD7874 Timing Diagram

## LCCC



## FEATURES

## Complete ADC with DSP Interface, Comprising: Track/Hold Amplifier with $2 \mu$ s Acquisition Time $7 \mu \mathrm{~s}$ A/D Converter 3 V Zener Reference <br> 8-Word FIFO and Interface Logic <br> 72 dB SNR at 10 kHz Input Frequency <br> Interfaces to High Speed DSP Processors, e.g., ADSP-2100, TMS32010, TMS32020 <br> 41 ns max Data Access Time <br> Low Power, 60 mW typ

APPLICATIONS
Digital Signal Processing
Speech Recognition and Synthesis
Spectrum Analysis
High Speed Modems
DSP Servo Control

## GENERAL DESCRIPTION

The AD7878 is a fast, complete 12-bit A/D converter with a versatile DSP interface consisting of an 8 -word, first-in, first-out (FIFO) memory and associated control logic.

The FIFO memory allows up to eight samples to be digitized before the microprocessor is required to service the A/D converter. The eight words can then be read out of the FIFO at maximum microprocessor speed. A fast data access time of 41 ns allows direct interfacing to DSP processors and high speed 16-bit microprocessors.

An on-chip status/control register allows the user to program the effective length of the FIFO and contains the FIFO out of range, FIFO empty and FIFO word count information.

The analog input of the AD7878 has a bipolar range of $\pm 3 \mathrm{~V}$. The AD7878 can convert full power signals up to 50 kHz and is fully specified for dynamic parameters such as signal-to-noise ratio and harmonic distortion.
The AD7878 is fabricated in Linear Compatible CMOS ( $L^{2}$ MOS), an advanced, mixed technology process that combines precision bipolar circuits with low power CMOS logic. The part is available in four package styles, 28-pin plastic and hermetic dual-in-line package (DIP), leadless ceramic chip carrier (LCCC) or plastic leaded chip carrier (PLCC).

## PRODUCT HIGHLIGHTS

1. Complete A/D Function with DSP Interface

The AD7878 provides the complete function for digitizing ac signals to 12-bit accuracy. The part features an on-chip track/ hold, on-chip reference and 12 -bit A/D converter. The additional feature of an 8 -word FIFO reduces the high software overheads associated with servicing interrupts in DSP processors.

## FUNCTIONAL BLOCK DIAGRAM


2. Dynamic Specifications for DSP Users The AD7878 is fully specified and tested for ac parameters, including signal-to-noise ratio, harmonic distortion and intermodulation distortion. Key digital timing parameters are also tested and specified over the full operating temperature range.
3. Fast Microprocessor Interface

Data access time of 41 ns is the fastest ever achieved in a monolithic A/D converter and makes the AD7878 compatible with all modern 16-bit microprocessors and digital signal processors.

ORDERING GUIDE

| Model ${ }^{1,2}$ | Temperature Range | Signal-to- <br> Noise Ratio | Data Access Time | Package Options ${ }^{3}$ |
| :---: | :---: | :---: | :---: | :---: |
| AD7878JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 70 dB | 57 ns | N-28 |
| AD7878AQ | $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 70 dB | 57 ns | Q-28 |
| AD7878SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 70 dB | 57 ns | Q-28 |
| AD7878KN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 72 dB | 57 ns | N-28 |
| AD7878BQ | $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 72 dB | 57 ns | Q-28 |
| AD7878LN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 72 dB | 41 ns | N-28 |
| AD7878SE ${ }^{4}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 70 dB | 57 ns | E-28A |
| AD7878JP | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 70 dB | 57 ns | P-28A |
| AD7878KP | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 72 dB | 57 ns | P-28A |
| AD7878LP | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 72 dB | 41 ns | P-28A |

[^50] complete data sheet, call our fax retrieval system at 1-800-446-6212.


| Parameter | J, A Versions ${ }^{1}$ | K, L, B Versions | s Version | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DYNAMIC PERFORMANCE ${ }^{2}$ |  |  |  |  |  |
| Signal-to-Noise Ratio (SNR) ${ }^{3}$ @ $25^{\circ} \mathrm{C}$ | 70 | 72 | 70 | dB min | $\mathrm{V}_{\mathrm{IN}}=10 \mathrm{kHz}$ Sine Wave, $\mathrm{f}_{\text {SAMPLE }}=100 \mathrm{kHz}$ |
| $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ | 70 | 71 | 70 | dB min | Typically 71.5 dB for $0<\mathrm{V}_{\text {IN }}<50 \mathrm{kHz}$ |
| Total Harmonic Distortion (THD) | -80 | -80 | -78 | dB max | $\mathrm{V}_{\text {IN }}=10 \mathrm{kHz}$ Sine Wave, $\mathrm{f}_{\text {SAMPLE }}=100 \mathrm{kHz}$ |
| Peak Harmonic or Spurious Noise | -80 | -80 | -78 | dB max | Typically -86 dB for $0<\mathrm{V}_{\mathrm{IN}}<50 \mathrm{kHz}$ <br> $\mathrm{V}_{\mathrm{IN}}=10 \mathrm{kHz}, \mathrm{f}_{\text {SAMPLE }}=100 \mathrm{kHz}$ <br> Typically -86 dB for $0<\mathrm{V}_{\mathrm{IN}}<50 \mathrm{kHz}$ |
| Intermodulation Distortion (IMD) |  |  |  |  |  |
| Second Order Terms | -80 | -80 | -78 | dB max | $\mathrm{fa}=9 \mathrm{kHz}, \mathrm{fb}=9.5 \mathrm{kHz}, \mathrm{f}_{\text {SAMPLE }}=50 \mathrm{kHz}$ |
| Third Order Terms | -80 | -80 | -78 | dB max | $\mathrm{fa}=9 \mathrm{kHz}, \mathrm{fb}=9.5 \mathrm{kHz}, \mathrm{f}_{\text {SAMPLE }}=50 \mathrm{kHz}$ |
| Track/Hold Acquisition Time | 2 | 2 | 2 | $\mu \mathrm{s}$ max | See Throughput Rate Section. |
| DC ACCURACY |  |  |  |  |  |
| Resolution | 12 | 12 | 12 | Bits |  |
| Minimum Resolution for which |  |  |  |  |  |
| No Missing Codes are Guaranteed | 12 | 12 | 12 | Bits |  |
| Relative Accuracy | $\pm 1 / 2$ | $\pm 1 / 4$ | $\pm 1 / 2$ | LSB typ |  |
| Differential Nonlinearity | $\pm 1 / 2$ | $\pm 1 / 2$ | $\pm 1 / 2$ | LSB typ |  |
| Bipolar Zero Error | $\pm 6$ | $\pm 6$ | $\pm 6$ | LSB max |  |
| Positive Full Scale Error ${ }^{4}$ | $\pm 6$ | $\pm 6$ | $\pm 6$ | LSB max |  |
| Negative Full Scale Error ${ }^{4}$ | $\pm 6$ | $\pm 6$ | $\pm 6$ | LSB max |  |
| ANALOG INPUT |  |  |  |  |  |
| Input Voltage Range | $\pm 3$ | $\pm 3$ | $\pm 3$ | Volts |  |
| Input Current | $\pm 550$ | $\pm 550$ | $\pm 550$ | $\mu \mathrm{A}$ max |  |
| REFERENCE OUTPUT ${ }^{5}$ |  |  |  |  |  |
| REF OUT | 3 | 3 | 3 | $V$ nom |  |
| REF OUT Error @ $25^{\circ} \mathrm{C}$ | $\pm 10$ | $\pm 10$ | $\pm 10$ | mV max |  |
| $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ | $\pm 15$ | $\pm 15$ | $\pm 15$ | mV max |  |
| Reference Load Sensitivity ( $\Delta$ REF OUT/ $\Delta$ I) | $\pm 1$ | $\pm 1$ |  | mV max | Reference Load Current Change ( $0-500 \mu \mathrm{~A}$ ). Reference Load Should Not Be Changed During Conversion. |
| LOGIC INPUTS |  |  |  |  |  |
| Input High Voltage, $\mathrm{V}_{\text {INH }}$ | +2.4 | +2.4 | +2.4 | $V$ min | $\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V} \pm 5 \%$ |
| Input Low Voltage, $\mathrm{V}_{\text {INL }}$ | +0.8 | +0.8 | +0.8 | V max | $\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V} \pm 5 \%$ |
| Input Current, $\mathrm{I}_{\text {IN }}$ | $\pm 10$ | $\pm 10$ | $\pm 10$ | $\mu \mathrm{A}$ max | $\mathrm{V}_{\text {IN }}=0$ to $\mathrm{V}_{\text {CC }}$ |
| Input Capacitance, $\mathrm{C}_{\text {IN }}{ }^{6}$ | 10 | 10 | 10 | pF max |  |
| LOGIC OUTPUTS |  |  |  |  |  |
| Output High Voltage, $\mathrm{V}_{\mathrm{OH}}$ | +2.7 | +2.7 | +2.7 | V min | $\mathrm{I}_{\text {SOURCE }}=40 \mu \mathrm{~A}$ |
| Output Low Voltage, $\mathrm{V}_{\text {OL }}$ | +0.4 | +0.4 | +0.4 | V max | $\mathrm{I}_{\text {SINK }}=1.6 \mathrm{~mA}$ |
| DB11-DB0 |  |  |  |  |  |
| Floating State Leakage Current | $\pm 10$ | $\pm 10$ | $\pm 10$ | $\pm 10$ | $\mu \mathrm{A}$ max |
| Floating State Output Capacitance ${ }^{6}$ | 15 | 15 | 15 | 15 | pF max |
| CONVERSION TIME |  |  |  |  |  |
|  | 7/7.125 | 7/7.125 | 7/7.125 | $\mu_{\mathrm{S}} \min / \mu_{\mathrm{S}} \max$ | Assuming No External Read/Write Operations |
|  | 7/9.250 | 7/9.250 | 7/9.250 | $\mu \mathrm{s} \min / \mu_{\mathrm{s}} \max$ | Assuming 17 External Read/Write Operations |
|  |  |  |  |  |  |
| POWER REQUIREMENTS |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{DD}}$ | +5 | +5 | +5 | V nom | $\pm 5 \%$ for Specified Performance |
| $\mathrm{V}_{\mathrm{cc}}$ | +5 | +5 | +5 | V nom | $\pm 5 \%$ for Specified Performance |
| $\mathrm{V}_{\text {ss }}$ | -5 | -5 | -5 | V nom | $\pm 5 \%$ for Specified Performance |
| $\mathrm{I}_{\text {DD }}$ | 13 | 13 | 13 | mA max | $\overline{\mathrm{CS}}=\overline{\mathrm{DMWR}}=\overline{\mathrm{DMRD}}=5 \mathrm{~V}$ |
| $\mathrm{I}_{\mathrm{Cc}}$ | 100 | 100 | 100 | $\mu \mathrm{A}$ max | $\overline{\mathrm{CS}}=\overline{\mathrm{DMWR}}=\overline{\text { DMRD }}=5 \mathrm{~V}$ |
| $\mathrm{I}_{\text {ss }}$ | 6 | 6 | 6 | mA max | $\overline{\mathrm{CS}}=\overline{\mathrm{DMWR}}=\overline{\mathrm{DMRD}}=5 \mathrm{~V}$ |
| Power Dissipation | 95.5 | 95.5 | 95.5 | mW max | Typically 60 mW |

[^51]TIMING CHARACTERISTICS ${ }^{1}\left(V_{D D}=5 \mathrm{~V} \pm 5 \%, V_{C C}=5 \mathrm{~V} \pm 5 \%, V_{S S}=-5 \mathrm{~V} \pm 5 \%\right)$

| Parameter | $\text { Limit at } \mathbf{T}_{\min }, \mathbf{T}_{\max }$ (L Grade) | Limit at $\mathrm{T}_{\text {min }}, \mathrm{T}_{\text {max }}$ (J, K, A, B Grades) | $\begin{aligned} & \text { Limit at } T_{\text {min }}, T_{\text {max }} \\ & \text { (S Grade) } \end{aligned}$ | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{1}$ | 65 | 65 | 75 | ns max | CLK IN to BUSY Low Propagation Delay |
| $\mathrm{t}_{2}$ | 65 | 65 | 75 | ns max | CLK IN to BUSY High Propagation Delay |
| $\mathrm{t}_{3}$ | 2 CLK IN cycles | 2 CLK IN cycles | 2 CLK IN cycles | min | CONVST Pulse Width |
| $\mathrm{t}_{4}$ | 0 | 0 | 0 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\text { DMRD }} /$ REGISTER ENABLE Setup Time |
| $\mathrm{t}_{5}$ | 0 | 0 | 0 | ns min | CS to DMRD/REGISTER ENABLE Hold Time |
| $\mathrm{t}_{6}$ | 45 | 60 | 60 | ns min | DMRD Pulse Width |
|  | 50 | 50 | 50 | $\mu \mathrm{s}$ max |  |
| $\mathrm{t}_{7}$ | 16 | 16 | 16 | ns min | ADD0 to $\overline{\text { DMRD/REGISTER ENABLE Setup Time }}$ |
|  | 0 | 0 | 0 | ns min | ADD0 to $\overline{\text { DMRD/REGISTER ENABLE Hold Time }}$ |
| $\mathrm{tg}^{2}$ | 41 | 57 | 57 | ns min | Data Access Time after DMRD |
| $\mathrm{t}_{10}{ }^{3}$ | 5 | 5 | 5 | ns min | Bus Relinquish Time |
|  | 45 | 45 | 45 | ns max |  |
| $\mathrm{t}_{11}$ | 42 | 42 | 55 | ns min | REGISTER ENABLE Pulse Width |
|  | 50 | 50 | 50 | $\mu \mathrm{s}$ max |  |
| $\mathrm{t}_{12}$ | 20 | 20 | 30 | ns min | Data Valid to REGISTER ENABLE Setup Time |
| $\mathrm{t}_{13}$ | 10 | 10 | 10 | ns min | Data Hold Time after REGISTER ENABLE |
| $\mathrm{t}_{14}{ }^{2}$ | 41 | 57 | 57 | ns min | Data Access Time after BUSY |
| $\mathrm{t}_{\text {RESET }}$ | 2 CLK IN cycles | 2 CLK IN cycles | 2 CLK IN cycles | min | RESET Pulse Width |

NOTES
${ }^{1}$ Timing Specifications in bold print are $100 \%$ production tested. All other times are sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance. All input signals are specified with $\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of 5 V$)$ and timed from a voltage level of 1.6 V .
${ }^{2} \mathrm{t}_{9}$ and $\mathrm{t}_{14}$ are measured with the load circuits of Figure 1 and defined as the time required for an output to cross 0.8 V or 2.4 V .
${ }^{3} \mathrm{t}_{10}$ is defined as the time required for the data lines to change 0.5 V when loaded with the circuits of Figure 2.
Specifications subject to change without notice.


Figure 1. Load Circuits for Access Time


Figure 2. Load Circuits for Output Float Delay

ABSOLUTE MAXIMUM RATINGS*
$\left(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right.$ unless otherwise stated)
$\mathrm{V}_{\mathrm{DD}}$ to DGND . . . . . . . . . . . . . . . . . . . -0.3 V to +7 V
$\mathrm{V}_{\mathrm{CC}}$ to DGND . . . . . . . . . . . . . . . . . . . . . -0.3 V to +7 V
$\mathrm{V}_{\text {SS }}$ to DGND . . . . . . . . . . . . . . . . . . . . +0.3 V to -7 V

AGND to DGND . . . . . . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
$\mathrm{V}_{\text {IN }}$ to AGND . . . . . . . . . . . . . . . . . . . . . -15 V to +15 V
REF OUT to AGND . . . . . . . . . . . . . . . . . . . . . 0 to V $_{\text {DD }}$
Digital Inputs to DGND
CLK IN, $\overline{\text { DMWR }}, \overline{\text { DMRD }}, \overline{\text { RESET, }}$

Digital Outputs to DGND

Data Pins
DB11-DB0 . . . . . . . . . . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Operating Temperature Range
J, K, L Versions . . . . . . . . . . . . . . . . . . . . . 0 to $+70^{\circ} \mathrm{C}$
A, B Versions . . . . . . . . . . . . . . . . . . . . $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
S Version . . . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 secs) . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Power Dissipation (Any Package) to $+75^{\circ} \mathrm{C}$. . . . . . 1000 mW
Derates above $+75^{\circ} \mathrm{C}$ by . . . . . . . . . . . . . . . . $10 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are removed.

| Pin <br> Number | Pin <br> Mnemonic | Function |
| :---: | :---: | :---: |
| 1 | ADD0 | Address Input. This control input determines whether the word placed on the output data bus during a read operation is a data word from the FIFO RAM or the contents of the status/control register. A logic low accesses the data word from Location 0 of the FIFO while a logic high selects the contents of the register (see Status/Control Register section). |
| 2 | $\overline{\mathrm{CS}}$ | Chip Select. Active low logic input. The device is selected when this input |
| 3 | $\overline{\text { DMWR }}$ | Data Memory Write. Active low logic input. $\overline{\mathrm{DMWR}}$ is used in conjunction with $\overline{\mathrm{CS}}$ low and ADD0 high to write data to the status/control register. Corresponds to $\overline{\mathrm{DMWR}}$ (ADSP-2100), $\mathrm{R} / \overline{\mathrm{W}}$ (MC68000, TMS32020), $\overline{\mathrm{WE}}$ (TMS32010). |
| 4 | $\overline{\text { DMRD }}$ | Data Memory READ. Active low logic input. $\overline{\mathrm{DMRD}}$ is used in conjunction with $\overline{\mathrm{CS}}$ low to enable the three-state output buffers. Corresponds directly to $\overline{\mathrm{DMRD}}$ (ADSP-2100), $\overline{\mathrm{DEN}}$ (TMS32010). |
| 5 | $\overline{\text { BUSY }}$ | Active low logic output. This output goes low when the ADC receives a CONVST pulse and remains low until the track/hold has gone into its hold mode. The three-state drivers of the AD7878 can be disabled while the $\overline{\mathrm{BUSY}}$ signal is low (see Extended READ/WRITE section). This is achieved by writing a logic 0 to DB5 ( $\overline{\text { DISO }}$ ) of the status/control register. Writing a logic 1 to DB5 of the status/control register allows data to be accessed from the AD7878 while $\overline{\mathrm{BUSY}}$ is low. |
| 6 | $\overline{\text { ALFL }}$ | FIFO Almost Full. A logic low indicates that the word count (i.e., number of conversion results) in the FIFO memory has reached the programmed word count in the status/control register. ALFL is updated at the end of each conversion. The $\overline{\text { ALFL }}$ output is reset to a logic high when a word is read from the FIFO memory and the word count is less than the preprogrammed word count. It can also be set high by writing a logic 1 to DB7 ( $\overline{\mathrm{ENAF}}$ ) of the status/control register. |
| 7 | DGND | Digital Ground. Ground reference for digital circuitry. |
| 8 | $\mathrm{V}_{\mathrm{CC}}$ | Digital supply voltage, $+5 \mathrm{~V} \pm 5 \%$. Positive supply voltage for digital circuitry. |
| 9 | DB11 | Data Bit 11 (MSB). Three-state TTL output, Coding for the data words in FIFO RAM is 2 s complement. |
| 10-15 | DB10-DB5 | Data Bit 10 to Data Bit 5. Three-state TTL input/outputs. |
| 16-19 | DB4-DB1 | Data Bit 4 to Data Bit 1. Three-state TTL outputs. |
| 20 | DB0 | Data Bit 0 (LSB). Three-state TTL output. |
| 21 | $V_{\text {DD }}$ | Analog positive supply voltage, $+5 \mathrm{~V} \pm 5 \%$. |
| 22 | AGND | Analog Ground. Ground reference for track/hold, reference and DAC. |
| 23 | REF OUT | Voltage Reference Output. The internal 3 V analog reference is provided at this pin. The external load capability of the reference is $500 \mu \mathrm{~A}$. |
| 24 | $\mathrm{V}_{\text {IN }}$ | Analog Input. Analog input range is $\pm 3 \mathrm{~V}$. |
| 25 | $\mathrm{V}_{\text {ss }}$ | Analog negative supply voltage, -5 $\mathrm{V} \pm 5 \%$. |
| 26 | CONVST | Convert Start. Logic input. A low to high transition on this input puts the track/hold into its hold mode and starts conversion. The $\overline{\text { CONVST }}$ input is asynchronous to CLK IN and is independent of $\overline{C S}, \overline{\mathrm{DMWR}}$ and $\overline{\mathrm{DMRD}}$. |
| 27 | $\overline{\text { RESET }}$ | Reset. Active low logic input. A logic low sets the words in FIFO memory to 100000000000 and resets the $\overline{\text { ALFL }}$ output and status/control register. |
| 28 | CLK IN | Clock Input. TTL-compatible logic input. Used as the clock source for the A/D converter. The mark-space ratio of this clock can vary from 35/65 to 65/35. |

## PIN CONFIGURATIONS



## FEATURES

12-Bit Monolithic A/D Converter<br>66 kHz Throughput Rate<br>$12 \mu$ s Conversion Time<br>$3 \mu \mathrm{~s}$ On-Chip Track/Hold Amplifier<br>\section*{Low Power}<br>Power Save Mode: $\mathbf{2} \mathbf{~ m W}$ typ<br>Normal Operation: $\mathbf{2 5} \mathbf{~ m W}$ typ<br>\section*{70 dB SNR}<br>Fast Data Access Time: 57 ns<br>Small 24-Lead SOIC and 0.3" DIP Packages

## APPLICATIONS

Battery Powered Portable Systems
Digital Signal Processing
Speech Recognition and Synthesis
High Speed Modems
Control and Instrumentation

## GENERAL DESCRIPTION

The AD7880 is a high speed, low power, 12-bit A/D converter which operates from a single +5 V supply. It consists of a $3 \mu \mathrm{~s}$ track/hold amplifier, a $12 \mu \mathrm{~s}$ successive-approximation ADC, versatile interface logic and a multiple-input-range circuit. The part also includes a power save feature.
An internal resistor network allows the part to accept both unipolar and bipolar input signals while operating from a single +5 V supply. Fast bus access times and standard control inputs ensure easy interfacing to modern microprocessors and digital signal processors.
The AD7880 features a total throughput time of $15 \mu \mathrm{~s}$ and can convert full power signals up to 33 kHz with a sampling frequency of 66 kHz .
In addition to the traditional dc accuracy specifications such as linearity, full-scale and offset errors, the AD7880 is also fully specified for dynamic performance parameters including harmonic distortion and signal-to-noise ratio.
The AD7880 is fabricated in Analog Devices' Linear Compatible CMOS (LC ${ }^{2}$ MOS) process, a mixed technology process that combines precision bipolar circuits with low power CMOS logic. The part is available in a 24 -pin, 0.3 inch-wide, plastic or hermetic dual-in-line package (DIP) as well as a small 24-lead SOIC package.

FUNCTIONAL BLOCK DIAGRAM


## PRODUCT HIGHLIGHTS

1. Fast Conversion Time.
$12 \mu \mathrm{~s}$ conversion time and $3 \mu \mathrm{~s}$ acquisition time allow for large input signal bandwidth. This performance is ideally suited for applications in areas such as telecommunications, audio, sonar and radar signal processing.
2. Low Power Consumption.

2 mW power consumption in the power-down mode makes the part ideally suited for portable, hand held, battery powered applications.
3. Multiple Input Ranges.

The part features three user-determined input ranges, 0 to $+5 \mathrm{~V}, 0$ to 10 V and $\pm 5 \mathrm{~V}$. These unipolar and bipolar ranges are achieved with a 5 V only power supply.
$\left(V_{D D}=+5 \mathrm{~V} \pm 5 \%, V_{\text {REF }}=V_{D D}, A G N D=D G N D=0 V, f_{\text {CLKIN }}=2.5 \mathrm{MHz}\right.$,
AD7880
MODE $=V_{D D}$ unless otherwise noted. All Specifications $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ unless otherwise noted.)

| Parameter | B Versions ${ }^{1}$ | C Versions ${ }^{1}$ | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: |
| DYNAMIC PERFORMANCE ${ }^{2}$ Signal-to-Noise Ratio ${ }^{3}$ (SNR) <br> Total Harmonic Distortion (THD) Peak Harmonic or Spurious Noise Intermodulation Distortion (IMD) Second Order Terms Third Order Terms | $\begin{aligned} & 70 \\ & -80 \\ & -80 \\ & -80 \\ & -80 \end{aligned}$ | $\begin{aligned} & 70 \\ & -80 \\ & -80 \\ & -80 \\ & -80 \end{aligned}$ | dB min <br> dB typ dB typ <br> dB typ <br> dB typ | Typically SNR Is 72 dB <br> $\mathrm{V}_{\text {IN }}=1 \mathrm{kHz}$ Sine Wave, $\mathrm{f}_{\text {SAMPLE }}=66 \mathrm{kHz}$ <br> $\mathrm{V}_{\mathrm{IN}}=1 \mathrm{kHz}$ Sine Wave, $\mathrm{f}_{\text {SAMPLE }}=66 \mathrm{kHz}$ <br> $\mathrm{V}_{\mathrm{IN}}=1 \mathrm{kHz}, \mathrm{f}_{\text {SAMPLE }}=66 \mathrm{kHz}$ <br> $\mathrm{fa}=0.983 \mathrm{kHz}, \mathrm{fb}=1.05 \mathrm{kHz}, \mathrm{f}_{\text {SAMPLE }}=66 \mathrm{kHz}$ <br> $\mathrm{fa}=0.983 \mathrm{kHz}, \mathrm{fb}=1.05 \mathrm{kHz}, \mathrm{f}_{\text {SAMPLE }}=66 \mathrm{kHz}$ |
| DC ACCURACY <br> Resolution <br> Integral Nonlinearity Differential Nonlinearity Full-Scale Error Bipolar Zero Error Unipolar Offset Error | $\begin{aligned} & 12 \\ & \pm 1 \\ & \pm 1 \\ & \pm 15 \\ & \pm 10 \\ & \pm 5 \end{aligned}$ | $\begin{aligned} & 12 \\ & \pm 1 \\ & \pm 1 \\ & \pm 5 \\ & \pm 5 \\ & \pm 5 \end{aligned}$ | Bits LSB max LSB max LSB max LSB max LSB max | All DC ACCURACY Specifications Apply for the Three Analog Input Ranges <br> Guaranteed Monotonic |
| ANALOG INPUT Input Voltage Ranges Input Resistance | $\begin{aligned} & 0 \text { to } \mathrm{V}_{\text {REF }} . \\ & 0 \text { to } 2 \mathrm{~V}_{\mathrm{REF}} \\ & \pm \mathrm{V}_{\mathrm{REF}} \\ & 10 \\ & 5 / 12 \\ & 5 / 12 \end{aligned}$ | $\begin{aligned} & 0 \text { to } \mathrm{V}_{\text {REF }} \\ & 0 \text { to } 2 \mathrm{~V}_{\text {REF }} \\ & \pm \mathrm{V}_{\mathrm{REF}} \\ & 10 \\ & 5 / 12 \\ & 5 / 12 \end{aligned}$ | Volts <br> Volts <br> Volts <br> $M \Omega$ min <br> $\mathrm{k} \Omega$ min/max <br> $\mathrm{k} \Omega \min /$ max | See Figure 5 <br> See Figure 6 <br> See Figure 7 <br> 0 to $\mathrm{V}_{\mathrm{REF}}$ Range <br> $8 \mathrm{k} \Omega$ typical: 0 to $2 \mathrm{~V}_{\mathrm{REF}}$ Range <br> $8 \mathrm{k} \Omega$ typical: $\pm \mathrm{V}_{\mathrm{REF}}$ Range |
| ```REFERENCE INPUT \(\mathrm{V}_{\text {REF }}\) (For Specified Performance) \(\mathrm{I}_{\mathrm{REF}}\) Nominal Reference Range``` | $\begin{aligned} & 5 \\ & 1.5 \\ & 2.5 / V_{\mathrm{DD}} \end{aligned}$ | $\begin{aligned} & 5 \\ & 1.5 \\ & 2.5 / V_{\mathrm{DD}} \end{aligned}$ | V <br> mA max <br> V min/max | $\pm 5 \%$ : Normally $\mathrm{V}_{\mathrm{REF}}=\mathrm{V}_{\mathrm{DD}}$ (See Reference Input Section) <br> See Figure 3 for Degradation in Performance Down to 2.5 V |
| $\overline{\text { LOGIC INPUTS }} \overline{\text { CONVST, }} \overline{\mathrm{RD}}, \overline{\mathrm{CS}}, \mathrm{CLKIN}$ <br> Input High Voltage, $\mathrm{V}_{\text {INH }}$ <br> Input Low Voltage, $\mathrm{V}_{\text {INL }}$ <br> Input Current, $\mathrm{I}_{\text {IN }}$ <br> Input Capacitance, $\mathrm{C}_{\mathrm{IN}}{ }^{4}$ <br> MODE INPUT <br> Input High Voltage, $\mathrm{V}_{\text {INH }}$ Input Low Voltage, $\mathrm{V}_{\mathrm{INL}}$ Input Current, $\mathrm{I}_{\mathrm{IN}}$ Input Capacitance, $\mathrm{C}_{\mathrm{IN}}{ }^{4}$ | $\begin{aligned} & 2.4 \\ & 0.8 \\ & \pm 10 \\ & 10 \\ & 4 \\ & 4 \\ & 1 \\ & \pm 125 \\ & 10 \end{aligned}$ | $\begin{aligned} & 2.4 \\ & 0.8 \\ & \pm 10 \\ & 10 \\ & 4 \\ & 1 \\ & \pm 125 \\ & 10 \end{aligned}$ | V min <br> V max <br> $\mu \mathrm{A}$ max <br> pF max <br> V min <br> V max <br> $\mu \mathrm{A}$ max <br> pF max | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V} \text { or } \mathrm{V}_{\mathrm{DD}}$ $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V} \text { or } \mathrm{V}_{\mathrm{DD}}$ |
| LOGIC OUTPUTS <br> DB11-DB0, $\overline{\text { BUSY }}$ <br> Output High Voltage, $\mathrm{V}_{\mathrm{OH}}$ <br> Output Low Voltage, $\mathrm{V}_{\mathrm{OL}}$ <br> DB11-DB0 <br> Floating-State Leakage Current Floating-State Output Capacitance ${ }^{4}$ | $\begin{aligned} & 4.0 \\ & 0.4 \\ & \pm 10 \\ & 10 \end{aligned}$ | $\begin{aligned} & 4.0 \\ & 0.4 \\ & \pm 10 \\ & 10 \end{aligned}$ | V min <br> V max <br> $\mu \mathrm{A}$ max <br> pF max | $\begin{aligned} & I_{\text {SOURCE }}=400 \mu \mathrm{~A} \\ & \mathrm{I}_{\text {SINK }}=1.6 \mathrm{~mA} \end{aligned}$ |
| CONVERSION <br> Conversion Time Track/Hold Acquisition Time | $\begin{aligned} & 12 \\ & 3 \end{aligned}$ | $\begin{aligned} & 12 \\ & 3 \end{aligned}$ | $\mu s$ max $\mu \mathrm{s}$ max | $\mathrm{f}_{\text {CLKIN }}=2.5 \mathrm{MHz}$ |
| ```POWER REQUIREMENTS \(V_{D D}\) \(I_{D D}\) Normal Power Mode @ \(+25^{\circ} \mathrm{C}\) \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) Power Save Mode @ \(+25^{\circ} \mathrm{C}\) \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) Power Dissipation Normal Power Mode @ \(+25^{\circ} \mathrm{C}\) \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) Power Save Mode @ \(+25^{\circ} \mathrm{C}\) \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\)``` | $\begin{aligned} & +5 \\ & 7.5 \\ & 10 \\ & 750 \\ & 1 \\ & \\ & 37.5 \\ & 50 \\ & 3.75 \\ & 5 \\ & \hline \end{aligned}$ | $\begin{aligned} & +5 \\ & \\ & 7.5 \\ & 10 \\ & 750 \\ & 1 \\ & \\ & 37.5 \\ & 50 \\ & 3.75 \\ & 5 \end{aligned}$ | V nom <br> mA max $m A$ max $\mu \mathrm{A}$ max mA max <br> mW max mW max mW max mW max | $\pm 5 \%$ for Specified Performance <br> Typically 4 mA ; MODE $=\mathrm{V}_{\mathrm{DD}}$ <br> Typically 5 mA ; MODE $=\mathrm{V}_{\mathrm{DD}}$ <br> Logic Inputs @ 0 V or $\mathrm{V}_{\mathrm{DD}} ;$ MODE $=0 \mathrm{~V}$ <br> Logic Inputs @ 0 V or $\mathrm{V}_{\mathrm{DD}} ; \mathrm{MODE}=0 \mathrm{~V}$ <br> $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$ : Typically $20 \mathrm{~mW} ;$ MODE $=\mathrm{V}_{\mathrm{DD}}$ <br> $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$ : Typically 25 mW ; MODE $=\mathrm{V}_{\mathrm{DD}}$ <br> $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$ : Typically 2 mW ; MODE $=0 \mathrm{~V}$ <br> $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$ : Typically $2.5 \mathrm{~mW} ; \mathrm{MODE}=0 \mathrm{~V}$ |

## NOTES

${ }^{1}$ Temperature Ranges are as follows: $\mathrm{B} / \mathrm{C}$ Versions, $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.
${ }^{2} \mathrm{~V}_{\text {IN }}=0$ to $\mathrm{V}_{\text {REF }}$.
${ }^{3}$ SNR calculation includes distortion and noise components.
${ }^{4}$ Sample tested @ $25^{\circ} \mathrm{C}$ to ensure compliance.
Specifications subject to change without notice.

TIMING CHARACTERISTICS ${ }^{1}$

$$
\left(V_{D D}=+5 V \pm 5 \%, V_{\text {REF }}=V_{D D}, A G N D=D G N D=0 V\right)
$$

| Parameter | Limit at $\mathbf{2 5}^{\circ} \mathrm{C}$ (All Versions) | Limit at $\mathbf{T}_{\text {min }}, \mathbf{T}_{\text {max }}$ (All Versions) | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{1}$ | 50 | 50 | ns min | CONVST Pulse Width |
| $\mathrm{t}_{2}$ | 130 | 130 | ns min | CONVST to BUSY Falling Edge |
| $\mathrm{t}_{3}$ | 0 | 0 | ns $\min$ | $\overline{\text { BUSY }}$ to $\overline{\text { CS }}$ Setup Time |
| $\mathrm{t}_{4}$ | 0 | 0 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{RD}}$ Setup Time |
| $\mathrm{t}_{5}$ | 0 | 0 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{RD}}$ Hold Time |
| $\mathrm{t}_{6}$ | 60 | 75 | ns min | $\overline{\mathrm{RD}}$ Pulse Width |
| $\mathrm{t}_{7}{ }^{2}$ | 57 | 70 | ns max | Data Access Time after $\overline{\mathbf{R D}}$ |
| $\mathrm{t}_{8}{ }^{3}$ | $\begin{aligned} & 5 \\ & 50 \end{aligned}$ | $\begin{aligned} & 5 \\ & 50 \end{aligned}$ | ns min ns $\max$ | Bus Relinquish Time after $\overline{\mathbf{R D}}$ |

## NOTES

${ }^{1}$ Timing specifications in bold print are $100 \%$ production tested. All other times are sample tested at $25^{\circ} \mathrm{C}$ to ensure compliance. All input signals are specified with $\mathbf{t r}=\mathbf{t f}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of 5 V ) and timed from a voltage level of 1.6 V .
${ }^{2}{ }^{2}$, is measured with the load circuit of Figure 2 and defined as the time required for an output to cross 0.8 V or 2.4 V .
${ }^{3} \mathrm{t}_{8}$ is derived from the measured time taken by the data outputs to change by 0.5 V when loaded with the circuit of Figure 2 . The measured number is then extrapolated back to remove the effects of charging the 50 pF capacitor. This means that the time, $\mathrm{t}_{8}$, quoted in the timing characteristics is the true bus relinquish time of the part and as such is independent of external bus loading capacitances.


Figure 1. Timing Diagram


Figure 2. Load Circuit for Access and Relinquish Time

Table I. AD7880 Truth Table

| $\overline{\overline{\mathbf{C S}}}$ | $\overline{\mathbf{C O N V S T}}$ | $\overline{\mathbf{R D}}$ | Function |
| :--- | :--- | :--- | :--- |
| 1 | 1 | $\mathbf{X}$ | Not Selected |
| 1 | $\boxed{\Sigma}$ | 1 | Start Conversion $\mathbf{\zeta}$ |
| 0 | 1 | 0 | Enable ADC Data |
| 0 | 1 | 1 | Data Bus Three Stated |

ABSOLUTE MAXIMUM RATINGS*
V $_{\text {DD }}$ to AGND . . . . . . . . . . . . . . . . . . . -0.3 V to +7 V
$\mathrm{V}_{\text {DD }}$ to DGND . . . . . . . . . . . . . . . . . . . . -0.3 V to +7 V
AGND to DGND . . . . . . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
$\mathrm{V}_{\text {INA }}, \mathrm{V}_{\text {INB }}$ to AGND (Fig 5) . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
$\mathrm{V}_{\text {INA }}$ to AGND (Fig 6) . . . . . . . . -0.6 V to $2 \mathrm{~V}_{\mathrm{DD}}+0.6 \mathrm{~V}$
$\mathrm{V}_{\text {INA }}$ to AGND (Fig 7) $\ldots \ldots-\mathrm{V}_{\mathrm{DD}}-0.3 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
$\mathrm{V}_{\text {REF }}$ to AGND . . . . . . . . . . . . . . . . . . . . . . 0.3 V to $\mathrm{V}_{\mathrm{DD}}$
Digital Inputs to DGND . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Digital Outputs to DGND . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Operating Temperature Range
Industrial (B, C Versions) . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 secs) . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Power Dissipation (Any Package) to $+75^{\circ} \mathrm{C}$. . . . . . 450 mW
Derates above $+75^{\circ} \mathrm{C}$ by . . . . . . . . . . . . . . . . . . $10 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are removed.


ORDERING GUIDE

|  | Temperature <br> Range | Full-Scale <br> Error <br> (LSBs) | Bipolar <br> Zero <br> Error <br> (LSBs) | Package <br> Option |
| :--- | :--- | :--- | :--- | :--- |
| AD ${ }^{\star}$ |  |  |  |  |

*N = Plastic DIP; $\mathbf{Q}=$ Cerdip; $\mathbf{R}=$ SOIC (Small Outline Integrated Circuit). For outline information see Package Information section.

PIN CONFIGURATION


## PIN FUNCTION DESCRIPTION

| Pin No. | Pin <br> Mnemonic | Function |
| :---: | :---: | :---: |
| 1 | $\mathrm{V}_{\text {INA }}$ | Analog Input. |
| 2 | $V_{\text {INB }}$ | Analog Input. |
| 3 | AGND | Analog Ground. |
| 4 | $\mathrm{V}_{\text {REF }}$ | Voltage Reference Input. This is normally tied to $\mathrm{V}_{\text {DD }}$ - |
| 5 | $\overline{\mathrm{CS}}$ | Chip Select. Active Low Logic input. The device is selected when this input is active. |
| 6 | CONVST | Convert Start. A low to high transition on this input puts the track/hold into hold mode and starts conversion. This input is asynchronous to the CLKIN and is independent of $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$. |
| 7 | $\overline{\mathrm{RD}}$ | Read. Active Low Logic Input. This input is used in conjunction with $\overline{\mathrm{CS}}$ low to enable data outputs. |
| 8 | $\overline{\text { BUSY }}$ | Active Low Logic Output. This status line indicates converter status. $\overline{\text { BUSY }}$ is low during conversion. |
| 9 | CLKIN | Clock Input. TTL-compatible logic input. Used as the clock source for the A/D converter. The mark/ space ratio of the clock can vary from $40 / 60$ to $60 / 40$. |
| 10 | DGND | Digital Ground. |
| $11 . . .22$ | DB0-DB11 | Three-State Data Outputs. These become active when $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ are brought low. |
| 23 | MODE | MODE Input. This input is used to put the device into the power save mode (MODE $=0 \mathrm{~V}$ ). During normal operation, the MODE input will be a logic high (MODE $=V_{D D}$ ). |
| 24 | $\mathrm{V}_{\text {DD }}$ | Power Supply. This is nominally +5 V . |

## FEATURES

$2.5 \mu \mathrm{~s}$ Throughput Time
16-Bit Sampling ADC
Self-Calibration
High Speed Parallel Interface
92 dB Signal-to-Noise Ratio
Low Power: 200 mW typ 1 mW in Power-Down Mode
Unipolar and Bipolar Input Signal Ranges
On-Chip 2.5 V Reference
Operates from $\pm 5 \mathrm{~V}$ Supplies

## APPLICATIONS

Data Acquisition Systems
Digital Signal Processing
Spectrum Analysis
DSP Servo Control

FUNCTIONAL BLOCK DIAGRAM


## PRODUCT HIGHLIGHTS

1. Fast $2,5 \mu \mathrm{~s}$ Throughput Time A fast $2.5 \mu$ s throughput time makes the AD7882 suitable for a wide range of data acquisition applications.
2. Self-Calibration Achieves High Accuracy

A self-calibrating algorithm minimizes linearity, offset and gain errors. The calibration procedure can also include external offset and gain errors.
3. Dynamic Specifications for DSP Users

In addition to traditional dc specifications, the AD7882 is specified for ac parameters including signal-to-noise ratio and harmonic distortion. These parameters along with important timing parameters are tested on every device.
4. Fast, Versatile Microprocessor Interface

Fast bus access times and standard control signals make the AD7882 easy to interface to microprocessors.
5. Low Power

Low power monolithic solution allows ease of application. The AD7882 also has a power down facility. earity, the AD7882 is also fully specified for dynamic performance parameters including harmonic distortion and signal-to-noise ratio (SNR).
The AD7882 is fabricated in Analog Devices' Linear Compatible CMOS (LC ${ }^{2}$ MOS), an advanced, mixed technology process that combines precision bipolar circuits with low power highspeed CMOS logic. The part is available in a 44 -pin plastic quad flatpack (PQFP) and 40-pin cerdip.

This is a preliminary data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

AD7882-SPEGFFG/TIONS $\left(\mathrm{AV}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \%, \mathrm{DV}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \%, \mathrm{AV}_{S S}=-5 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{REFIN}}=2.5 \mathrm{~V}\right.$, AGND $=D G N D=0 \mathrm{~V}, \mathrm{f}_{\text {CLKIN }}=10 \mathrm{MHz}, \mathrm{f}_{\text {SAMPLE }}=400 \mathrm{kHz}$. All specifications $\mathrm{T}_{\text {MIM }}$ to $\mathrm{T}_{\text {MAX }}$ unless otherwise noted.)

| Parameter | $\underset{\text { Versions }}{ }{ }^{\mathbf{1}}$ | $\begin{aligned} & \mathbf{B}, \mathbf{T} \\ & \text { Versions }^{1} \end{aligned}$ | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: |
| DYNAMIC PERFORMANCE ${ }^{2}$ |  |  |  |  |
| Signal to (Noise + Distortion Ratio) | 90 | 90 | dB min | $\mathrm{A}_{\text {IN }}=10 \mathrm{kHz}$, Typical SNR $=92 \mathrm{~dB}$ |
|  | 85 | 85 | dB min | $\mathrm{A}_{\text {IN }}=100 \mathrm{kHz}$, Typical SNR $=87 \mathrm{~dB}$ |
| THD | -95 | -95 | dB max | $\mathrm{A}_{\text {IN }}=10 \mathrm{kHz}$, Typical THD $=-100 \mathrm{~dB}$ |
|  | -88 | -88 | dB max | $\mathrm{A}_{\text {IN }}=100 \mathrm{kHz}$, Typical THD $=-90 \mathrm{~dB}$ |
| Peak Harmonic or Spurious Noise | -98 | -98 | dB max | $\mathrm{A}_{\text {IN }}=10 \mathrm{kHz}$, Typical Peak Harmonic $=-100 \mathrm{~dB}$ |
|  | -90 | -90 | dB max | $\mathrm{A}_{\text {IN }}=100 \mathrm{kHz}$, Typical Peak Harmonic $=-92 \mathrm{~dB}$ |
| Intermodulation Distortion (IMD) |  |  |  |  |
| 2nd Order Terms | -88 | -88 | dB max | $\mathrm{f}_{\mathrm{A}}=98 \mathrm{kHz}, \mathrm{f}_{\mathrm{B}}=100 \mathrm{kHz}$ |
| 3rd Order Terms | -88 | -88 | dB max |  |
| Throughput Time | 2.5 | 2.5 | $\mu \mathrm{s}$ max |  |
| Aperture Delay | 10 | 10 | ns typ |  |
| Aperture Jitter | 20 | 20 | ps typ |  |
| Noise | 70 | 70 | $\mu \mathrm{V}$ rms typ |  |
| DC ACCURACY ${ }^{2}$ |  |  |  |  |
| Resolution | 16 | 16 | Bits |  |
| Minimum Resolution for Which No Missing |  |  |  |  |
| Integral Nonlinearity | $\pm 1 / 2$ | $\pm 1 / 2$ | LSB typ | - - |
| Integral Nonlinearity |  | $\pm 1.0$ | LSB max | - |
| Differential Nonlinearity | $\pm 0.9$ | $\pm 0.5$ | LSB max | 2. ${ }^{\text {a }}$ |
| Unipolar Offset Error | $\pm 2$ | $\pm 2$ | LSB max |  |
| Unipolar Gain Error | $\pm 2$ | $\pm 2$ | LSB max ${ }^{\text {a }}$ |  |
| Bipolar Zero Error | $\pm 2$ | $\pm 2$ | LSB max | - 12 |
| Bipolar Positive Gain Error | $\pm 2$ | $\pm 2$ - | LSB max |  |
| Bipolar Negative Gain Error | $\pm 2$ | $\pm 2$, | LSB max |  |
| POWER SUPPLY REJECTION <br> $\mathrm{AV}_{\mathrm{DD}}$ Only <br> AV Ss Only | $\begin{aligned} & 84 \\ & 84 \end{aligned}$ | 84 84 |  |  |
| ANALOG I/P |  |  |  |  |
| Input Current | $\pm 1$ | $\pm 1$ | $\mu \mathrm{A}$ max | Input Range $=0 \mathrm{~V}$ to +2.5 V or $\pm 2.5 \mathrm{~V}$ |
| Input Capacitance ${ }^{3}$ | 20 | 20 | pF max |  |
| REFERENCE OUTPUT |  |  |  |  |
| $\mathrm{V}_{\text {Refout }}$ @ $+25^{\circ} \mathrm{C}$ | 2.5 | 2.5 | Volts Nominal | $\pm 1 \%$ |
| $\mathrm{V}_{\text {Refout }}$ Tempco | 20 | 20 | $\mathrm{ppm} /{ }^{\circ} \mathrm{C} \text { typ }$ |  |
| REFERENCE INPUT |  |  |  |  |
| $\mathrm{V}_{\text {Refin }}$ Range | 2.5 | 2.5 | Volts | $\pm 2 \%$ |
| $\mathrm{V}_{\text {Refin }}$ Current | $\pm 1$ | $\pm 1$ | $\mu \mathrm{A}$ max |  |
| LOGIC INPUTS |  |  |  |  |
| Input High Voltage, $\mathrm{V}_{\text {INH }}$ | 2.4 | 2.4 | Volts min |  |
| Input Low Voltage, $\mathrm{V}_{\text {INL }}$ | 0.8 | 0.8 | Volts max |  |
| Input Current | $\pm 10$ | $\pm 10$ | $\mu \mathrm{A}$ max |  |
| Input Capacitance ${ }^{3}$ | 10 | 10 | pF max |  |
| $\overline{\text { SLEEP INPUT }}$ |  |  |  |  |
| Input High Voltage, $\mathrm{V}_{\text {INH }}$ | $\mathrm{V}_{\mathrm{DD}}-0.2$ | $\mathrm{V}_{\mathrm{DD}}-0.2$ | Volts min |  |
| Input Low Voltage, $\mathrm{V}_{\text {INL }}$ | 0.2 | 0.2 | Volts max |  |
| CLKIN INPUT |  |  |  |  |
| Negative Trigger Level | -2 | -2 | Volts min | This is the Trigger Level for Choosing Internal Clock Operation of the Device |

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

| Parameter | $\underset{\text { Versions }{ }^{1}}{\text { A, }}$ | $\begin{aligned} & \hline \mathbf{B}, \mathbf{T} \\ & \text { Versions }{ }^{1} \end{aligned}$ | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: |
| LOGIC OUTPUTS <br> Output High Voltage, $\mathrm{V}_{\mathrm{OH}}$ Output Low Voltage, $\mathrm{V}_{\text {OL }}$ DB15-DB0 Floating-State Leakage Current Floating-State Output Capacitance ${ }^{3}$ | $\begin{aligned} & 2.4 \\ & 0.4 \\ & \pm 10 \\ & 20 \end{aligned}$ | $\begin{aligned} & 2.4 \\ & 0.4 \\ & \pm 10 \\ & 20 \end{aligned}$ | Volts min Volts max <br> $\mu \mathrm{A}$ max pF max | $\begin{aligned} & \mathrm{I}_{\text {SOURCE }}=200 \mu \mathrm{~A} \\ & \mathrm{I}_{\text {SINK }}=1.6 \mathrm{~mA} \end{aligned}$ |
| POWER REQUIREMENTS <br> $D V_{D D}$ <br> $A V_{D D}$ <br> $\mathrm{AV}_{\text {ss }}$ <br> Normal Mode <br> $\mathrm{DI}_{\mathrm{DD}}$ <br> $\mathrm{AI}_{\mathrm{DD}}$ <br> $\mathrm{Al}_{\text {ss }}$ <br> Power Dissipation <br> Sleep Mode <br> $\mathrm{DI}_{\mathrm{DD}}$ <br> $\mathrm{AI}_{\mathrm{DD}}$ <br> $\mathrm{Al}_{s \mathrm{~s}}$ <br> Power Dissipation | $\begin{aligned} & +5 \\ & +5 \\ & -5 \\ & \\ & 1 \\ & 29 \\ & 27 \\ & 300 \\ & \\ & 40 \\ & 50 \\ & 40 \\ & 1 \end{aligned}$ | $\begin{aligned} & +5 \\ & +5 \\ & -5 \\ & \\ & 1 \\ & 29 \\ & 27 \\ & 300 \\ & \\ & 40 \\ & 50 \\ & 40 \\ & 1 \end{aligned}$ | Volts <br> Volts <br> Volts <br> mA max mA max mA max mW max <br> $\mu \mathrm{A}$ max $\mu \mathrm{A}$ max $\mu \mathrm{A}$ max mW max | $\begin{aligned} & \pm 5 \% \\ & \pm 5 \% \\ & \pm 5 \% \end{aligned}$ <br> Typically 200 mW , CLKIN not Running <br> Typically $500 \mu \mathrm{~W}$, Input Logic Levels of 0.2 V and $\mathrm{V}_{\mathrm{DD}}-0.2 \mathrm{~V}$, CLKIN Not Running. Typically 1.5 mW with CLKIN Running |

## NOTES

${ }^{1}$ Temperature ranges are as follows: A, B Versions: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; S , T Versions: $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
${ }^{2}$ Specifications apply after calibration.
${ }^{3}$ Sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance.
Specifications subject to change without notice.

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

$$
\text { TIMING SPECIFICATIONS1 }{ }^{1} \begin{aligned}
& \left(A V_{D D}=5 \mathrm{~V} \pm 5 \%, ~ D V_{D D}=5 \mathrm{~V} \pm 5 \%, A V_{S S}=-5 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\text {REFIN }}=2.5 \mathrm{~V}, \operatorname{AGND}=\operatorname{DGND}=0 \mathrm{~V},\right. \\
& \left.\mathrm{f}_{\text {CLIN }}=10 \mathrm{MHz}, \mathrm{f}_{\text {SMMPLE }}=400 \mathrm{kHz} \text {. All specifications } \mathrm{T}_{\text {MIN }} \text { to } \mathrm{T}_{\text {MAX }} \text { unless otherwise noted. }\right)
\end{aligned}
$$

| Parameter | Limit @ $+25^{\circ} \mathrm{C}$ <br> (All Versions) | Limit @ $\mathbf{T}_{\text {MIN }}$, T $_{\text {MAX }}$ (A, B Versions) | Limit @ TMIN, $\mathrm{T}_{\text {MAX }}$ (S, T Versions) | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{1}$ | 10 | 15 | 20 | ns min | ADD0 to $\overline{\mathrm{WR}}$ Setup Time |
| $\mathrm{t}_{2}$ | 5 | 5 | 10 | ns min | ADD0 to $\overline{\mathrm{WR}}$ Hold Time |
| $\mathrm{t}_{3}$ | 10 | 15 | 20 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{WR}}$ Setup Time |
| $\mathrm{t}_{4}$ | 5 | 5 | 10 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{WR}}$ Hold Time |
| $\mathrm{t}_{5}$ | 30 | 40 | 50 | ns min | $\overline{\text { WR Pulse Width }}$ |
| $\mathrm{t}_{6}$ | 30 | 40 | 50 | ns min | Data Setup Time |
| $\mathrm{t}_{7}$ | 5 | 5 | 10 | $n \mathrm{~ns} \min$ | Data Hold Time |
| $\mathrm{t}_{\text {CONVERT }}$ | $22 \mathrm{t}_{\text {clikin }}$ | $22 \mathbf{t}_{\text {cLikin }}$ | $22 \mathrm{t}_{\text {cLKin }}$ |  | Conversion Time: Synchronous Operation |
|  | 2.3 | 2.3 | 2.3 | $\mu \mathrm{s}$ max | Conversion Time: Internal Clock Operation |
| $\mathrm{t}_{\text {SAMPLE }}$ | $25 \mathrm{t}_{\text {cLikin }}$ | $25 \mathbf{t}_{\text {cLKIN }}$ | $25 \mathrm{t}_{\text {CLKIN }}$ |  | Time Between Samples: Synchronous Operation |
|  | 2.6 | 2.6 | 2.6 | $\mu \mathrm{s}$ max | Time Between Samples: Internal Clock Operation |
| $\mathrm{t}_{8}$ | 30 | 40 | 50 | ns min | CONVST Pulse Width |
| $\mathrm{t}_{9}$ | 20 | 30 | 40 | ns max | CONVST High to BUSY Low Delay |
| $\mathrm{t}_{10}$ | 0 | 0 | 0 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{RD}}$ Setup Time |
| $\mathrm{t}_{11}$ | 0 | 0 | 0 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{RD}}$ Hold Time |
| $\mathrm{t}_{12}$ | 40 | 50 | 60 | $n \mathrm{~ns}$ min | $\overline{\mathrm{RD}}$ Pulse Width |
| $\mathrm{t}_{13}{ }^{2}$ | 40 | 50 | 60 | ns max | $\overline{\mathrm{RD}}$ Low to Data Valid Delay (Data Access Time) |
| $\mathrm{t}_{14}{ }^{3}$ | 10 | 10 | 10 | ns min | Data Hold Time After $\overline{\mathrm{RD}}$ (Bus Relinquish Time) |
|  | 75 | 75 | 75 | ns max |  |
| $\mathrm{t}_{15}$ | 10 | 15 | 20 | ns min | ADDO to $\overline{\mathrm{RD}}$ Setup Time |
| $\mathrm{t}_{16}$ | 5 | 5 | 10 - | ns min | ADDO to RD Hold Time |
| $\mathrm{t}_{17}$ | 40 | 40 | 50 | ns min | New Data Valid before Rising Edge of $\overline{\text { BUSY }}$ |
| $\mathrm{t}_{18}$ | 20 | 30 | $40 \times+\quad$ ? | ns max | CLKIN Falling Edge to BUSY Low Delay |
| $\mathrm{t}_{19}$ | 10 | 20 | 30 - | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{CAL}}$ Setup Time |
| $\mathrm{t}_{20}$ | 0 | 0 |  | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{CAL}}$ Hold Time |
| $\mathrm{t}_{21}$ | 30 | 40 | $50-$ | ns min. | CAL Pulse Width |
| $\mathrm{t}_{22}$ | 20 | 30 |  | ns max | $\overline{\text { CAL }}$ High to $\overline{\text { BUSY }}$ Low Delay |
| $\mathrm{t}_{23}$ | 20 | 30 | 40 | ns max | CONVST High to $\overline{\text { BUSY }}$ Low Delay: System CAL Mode |
| $\mathrm{t}_{\text {CAL } 1}$ | $9276744 \mathrm{t}_{\text {CLKIN }}$ |  |  |  | Device Calibration Time: Device CAL Mode |
| $\mathrm{t}_{\text {CAL } 2}$ | $6359324 \mathrm{t}_{\text {CLKIN }}$ |  |  |  | DAC Calibration Time: System CAL Mode |
| $\mathrm{t}_{\text {CAL }}$ | $1475104 \mathrm{t}_{\text {CLKIN }}$ |  |  |  | Offset Calibration Time: System CAL Mode |
| ${ }^{\text {t }}$ CAL4 | $1442324 \mathrm{t}_{\text {CLKIN }}$ |  |  |  | Gain Calibration Time: System CAL Mode |

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Figure 1. Load Circuit for Bus Access and Relinquish Time


Figure 2. Write Timing Diagram


Figure 3. Read Timing Diagram, Asynchronous Operation ( $M / S=$ Low; $\overline{C A L}=$ High $)$


Figure 4. Read Timing Diagram, Asynchronous Operation (M/S, $\overline{C S}, \overline{R D}, A D D O=L o w ; \overline{C A L}=H i g h)$

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Figure 5. Read Timing Diagram, Synchronous Operation ( $\overline{C S}, \overline{R D}=$ Low: $M / S, \overline{C A L}=$ High)


Figure 6. Device Calibration Timing ( $M / S=L o w, \overline{R D}, \overline{W R}=$ High $)$


Figure 7. System Calibration Timing (M/S = High; $\overline{R D}, \overline{W R}=$ High $)$

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## ABSOLUTE MAXIMUM RATINGS ${ }^{\mathbf{1 , 2}}$

( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)

| $A V_{D D}$ to AGND | V |
| :---: | :---: |
| $A V_{\text {Ss }}$ to AGND | +0.3 V to -7 V |
| AGND to DGND | -0.3 V to +0.3 V |
| $\mathrm{AV}_{\mathrm{DD}}$ to $\mathrm{DV}_{\mathrm{DD}}$ | -0.3 V to +0.3 V |
| Analog Inputs to AGND | to $\mathrm{AV}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| Reference Inputs to AGND . . . A | V to $\mathrm{AV}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| Digital Inputs to DGND | V to $\mathrm{DV}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| Digital Outputs to DGND | V to $\mathrm{DV}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| Operating Temperature Range |  |
| Commercial Plastic (A, B Versions) | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Extended Hermetic (S, T Versions) | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Storage Temperature Range. | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Junction Temperature | $+150^{\circ} \mathrm{C}$ |
| Lead Temperature (Soldering, 10 sec ) | $+300^{\circ} \mathrm{C}$ |
| Cerdip Package, Power Dissipation | 1000 mW |
| $\theta_{\mathrm{JA}}$ Thermal Impedance | $50^{\circ} \mathrm{C} / \mathrm{W}$ |
| Lead Temperature, Soldering |  |
| Vapor Phase ( $60 \mathrm{sec} \mathrm{)}$ | $+215^{\circ} \mathrm{C}$ |
| Infrared (15 sec) | $+220^{\circ} \mathrm{C}$ |
| PQFP Package, Power Dissipation | .875 mW |
| $\theta_{\mathrm{JA}}$ Thermal Impedance | $75^{\circ} \mathrm{C} / \mathrm{W}$ |
| Lead Temperature, Soldering |  |
| Vapor Phase ( $60 \mathrm{sec} \mathrm{)}$ |  |
| Infrared (15 sec) | $+220^{\circ} \mathrm{C}$ |

## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ Transient currents of up to 100 mA will not cause SCR latch-up.

PQFP Pinout


## Cerdip Pinout



## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD7882 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


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## PIN FUNCTION DESCRIPTION

| Pin Mnemonic | Function |
| :---: | :---: |
| Power Supply |  |
| DV ${ }_{\text {DD }}$ | Digital positive supply, $+5 \mathrm{~V} \pm 5 \%$. |
| $\mathrm{AV}_{\text {S }}$ | Analog negative supply, $-5 \mathrm{~V} \pm 5 \%$. |
| $\mathrm{AV}_{\mathrm{DD}}$ | Analog positive supply, $+5 \mathrm{~V} \pm 5 \%$. |
| DGND | Digital Ground. Ground reference for digital circuitry. |
| AGND | Analog Ground. Ground reference for analog circuitry. |
| Analog and Reference Pins |  |
| $\mathrm{A}_{\text {IN }} 1, \mathrm{~A}_{\text {IN }} 2$ | Analog Inputs. Both analog inputs must be tied together. The input ranges are; 0 V to 2.5 V and $\pm 2.5 \mathrm{~V}$. |
| $\mathrm{V}_{\text {REFIN }}$ | Voltage Reference Input. The AD7882 is specified with a voltage reference of 2.5 V , which can be provided externally or by the on-chip voltage reference. |
| $\mathrm{V}_{\text {REFOUT }}$ | Voltage Reference Output. The internal 2.5 V reference is provided at this pin. It has an output impedance which is nominally $20 \mathrm{k} \Omega$. |
| $\mathrm{C}_{\text {REF1 }}$ | $10 \mu \mathrm{~F}$ Reference Capacitor. This is a charge reservoir for the coarse internal reference buffer, and it damps voltage excursions at the buffer output. This must be a high quality, low series inductance capacitor. |
| $\mathrm{C}_{\text {REF2 }}$ | $0.2 \mu \mathrm{~F}$ Reference Capacitor. This is a charge reservoir for the fine internal reference buffer, and it damps voltage excursions at the buffer output. This must be a high quality, low series inductance capacitor. |
| Interface <br> $\overline{\mathrm{RD}}$ |  |
| $\overline{\mathrm{CS}}$ | Read, active low logic input. This input is used in conjunction with CS low to enable the three-state data outputs. Chip select, active low logic input. The device is selected when this input is active. |
| ADD0 | Address Input. This control input determines whether the word placed on the output data bus during a read operation is an ADC conversion result or the contents of the control register. A logic low accesses a conversion result while a logic high accesses the control register. When writing, if ADD0 is high, the control register is the destination. If ADD0 is low, the calibration data memory is the destination. |
| $\overline{\mathrm{WR}}$ | Write, active low logic input. This input is used in conjunction with $\overline{\mathrm{CS}}$ and ADD0 to write data to the AD7882. |
| DB15-DB0 | Three-state data outputs which are controlled by $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$. Data output coding is 2 s complement binary. |
| Timing and Control |  |
| CLKIN | Clock input, an external TTL-compatible clock may be applied to this input pin. Alternatively, tying this pin to $\mathrm{AV}_{\text {SS }}$ enables the internal clock oscillator. |
| $\overline{\text { BUSY }}$ | This output indicates converter status. $\overline{\text { BUSY }}$ is low during conversion and calibration. |
| CONVST | Conversion Start. A low to high transition on this logic input pin, when the AD7882 is configured for asynchronous operation, places the sample-and-hold amplifier in the hold mode and starts conversion. |
| $\mathrm{BIP} / \overline{\mathrm{UP}}$ | Bipolar/Unipolar select logic input. A logic high selects the bipolar input range ( $A_{\text {IN }}$ Range $= \pm \mathrm{V}_{\text {REFIN }}$ ), and a logic low selects the unipolar range ( $\mathrm{A}_{\text {IN }}$ Range $=0$ to $\mathrm{V}_{\text {REFIN }}$ ). |
| $\overline{\text { SLEEP }}$ | Sleep function, active low logic input. Once asserted, the AD7882 enters the low power mode. All internal circuitry including the internal voltage reference is powered down. Calibration data is retained. |
| $\overline{\text { CAL }}$ | Active low logic input. A logic low on this input resets all internal logic and initiates a calibration. Initiating a calibration overrides all other internal operations and if a conversion is in progress, it will be terminated. |
| M/S | Mode/Sync Logic Input. This is a dual function pin. When the device is in the CAL mode ( $\overline{\mathrm{CAL}}$ input low), it determines the calibration mode. When the device is in the normal operating mode, it determines whether conversion is synchronous or asynchronous. Synchronous operation means that the device continuously converts the input in synchronism with the clock. Asynchronous operation means that the device converts the analog input in response to the application of a CONVST signal. See Table I for the $\overline{\mathrm{CAL}}, \mathrm{M} / \mathrm{S}$ Truth Table. Note that the control register can be used to disable this input pin. See Control Register Section. |

Table I. AD7882 Operating Modes

| $\overline{\mathbf{C A L}}$ | M/S | Function |
| :--- | :--- | :--- |
| 1 | 0 | Asynchronous Operation |
| 1 | 1 | Synchronous Operation |
| 0 | 0 | Device Calibration |
| 0 | 1 | System Calibration |

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## TERMINOLOGY

## Integral Nonlinearity

This is the maximum deviation of any code from a straight line passing through the endpoints of the ADC transfer function. The endpoints of the transfer function are zero scale (not to be confused with bipolar zero), a point 0.5 LSB below the first code transition ( $000 \ldots 000$ to $000 \ldots 001$ ) and full scale, a point 0.5 LSB above the last code transition ( $111 \ldots 110$ to 111... 111). The error is expressed in LSBs.

## Differential Nonlinearity/No Missed Codes

This is the difference between the measured and the ideal 1 LSB change between any two adjacent codes in the ADC. Differential linearity error is expressed in LSBs. A differential linearity error of $\pm 0.9$ LSB or less guarantees no missed codes to the full resolution of the device. Thus, the AD7882 has no missed codes guaranteed to 16 bits.

## Unipolar Offset Error

When the device is operating in the 0 to $+\mathrm{V}_{\text {REFIN }}$ range, the deviation of the first code transition from the ideal ( +0.5 LSB ) is the unipolar offset error. It is expressed in LSBs.

## Unipolar Gain Error

This is the deviation of the last code transition ( $01 \ldots 110$ to $01 \ldots 111$ ) from the ideal ( $\mathrm{V}_{\text {REFIN }}-1.5 \mathrm{LSB}$ ) after bipolar zero error has been adjusted out.

## Bipolar Zero Error

This is the deviation of the midscale transition (all 0 s to all 1 s ) from the ideal (AGND).

## Positive Gain Error

This is the deviation of the last code transition ( 01.110 to $01 \ldots 111$ ) from the ideal ( $\mathrm{V}_{\text {REFIN }}-1.5 \mathrm{LSB}$ ) after bipolar zero error has been adjusted out.

## Negative Gain Error

This is the deviation of the first code transition ( $10 \ldots 000$ to $10 \ldots 001$ ) from the ideal $\left(-\mathrm{V}_{\mathrm{REFIN}}+0.5 \mathrm{LSB}\right)$ after bipolar zero error has been adjusted out.

## Signal to (Noise + Distortion) Ratio

This is the measured ratio of signal to (noise + distortion) at the output of the $\mathrm{A} / \mathrm{D}$ converter. The signal is the rms amplitude of the fundamental. Noise is the rms sum of all nonfundamental signals up to half the sampling frequency ( $\mathrm{f}_{\mathrm{S}} / 2$ ), excluding dc. The ratio is dependent upon the number of quantization levels in the digitization process; the more levels, the smaller the quantization noise. The theoretical signal to (noise +distortion) ratio for an ideal N -bit converter with a sine wave input is given by:

$$
\text { Signal to }(\text { Noise }+ \text { Distortion })=(6.02 N+1.76) \mathrm{dB}
$$

Thus for a 16 -bit converter, this is 98 dB .

## Total Harmonic Distortion

Total harmonic distortion (THD) is the ratio of the rms sum of harmonics to the fundamental. For the AD7882, it is defined as

$$
T H D(d B)=20 \log \frac{\sqrt{V_{2}^{2}+V_{3}^{2}+V_{4}^{2}+V_{5}^{2}+V_{6}^{2}}}{V_{1}}
$$

where $V_{1}$ is the rms amplitude of the fundamental and $V_{2}, V_{3}$, $\mathrm{V}_{4}, \mathrm{~V}_{5}$ and $\mathrm{V}_{6}$ are the rms amplitudes of the second through the sixth harmonics.

## Peak Harmonic or Spurious Noise

Peak harmonic or spurious noise is defined as the ratio of the rms value of the next largest component in the ADC output spectrum (up to $\mathrm{f}_{\mathrm{S}} / 2$ and excluding dc) to the rms value of the fundamental. Normally, the value of this specification is determined by the largest harmonic in the spectrum, but for parts where the harmonics are buried in the noise floor, it will be a noise peak.

## Intermodulation Distortion

With inputs consisting of sine waves at two frequencies, fa and fb , any active device with nonlinearities will create distortion products at sum and difference frequencies of $\mathrm{mfa} \pm \mathrm{nfb}$ where $\mathrm{m}, \mathrm{n}=0,1,2,3$, etc. Intermodulation terms are those for which neither $m$ nor $n$ are equal to zero. For example, the second order terms include $(\mathrm{fa}+\mathrm{fb})$ and $(\mathrm{fa}-\mathrm{fb})$, while the third order terms include $(2 \mathrm{fa}+\mathrm{fb}),(2 \mathrm{fa}-\mathrm{fb}),(\mathrm{fa}+2 \mathrm{fb})$ and $(\mathrm{fa}-$ 2 fb ).
The AD7882 is tested using the CCIF standard where two input frequencies neat the top end of the input bandwidth are used. In this case, the second and third order terms are of different significance. The second order terms are usually distanced in frequency from the original sine waves, while the third order terms are usually at a frequency close to the input frequencies. As a result, the second and third order terms are specified separately. The calculation of the intermodulation distortion is as per the THD specification where it is the ratio of the rms sum of the individual distortion products to the rms amplitude of the fundamental expressed in dBs.

## Power Supply Rejection Ratio

This is the ratio, in dBs , of the change in positive gain error to the change in $A V_{D D}, D V_{D D}$ or $A V_{S S}$. It is a dc measurement.

[^53]
## CIRCUIT DESCRIPTION

## Analog Input

The analog input circuitry includes two SHAs in a ping-pong configuration as in Figure 8. The SHAs alternatively acquire the analog input and hold the output constant for the ADC conversions. During conversion, one of the SHAs is in the hold mode while the other is in the sample mode. The sample and


Figure 8. Input SHA Configuration
hold states are then switched after every conversion. The benefit of this configuration is to eliminate the need for acquisition time between conversions. The throughput time is now effectively equal to the conversion time which is $2.5 \mu \mathrm{~s}$. The analog input range can be either unipolar or bipolar depending on the status of the BIP/UP input. The transfer function for the unipolar range is straight binary while the transfer function for the bipolar input is 2 s complement. These are shown in Figures 9 and 10.


Figure 9. Unipolar Transfer Function


Figure 10. Bipolar Transfer Function

## Calibration

The AD7882 conversion procedure is based on the successive approximation algorithm. Accuracy of the individual components, such as the DAC and comparator, is critical to achieve 16 -bit performance. The comparator uses an autozero technique to null both internal and external offsets. Another advantage of this scheme is that it nulls $1 / \mathrm{f}$ noise. The autozero switching occurs well above the $1 / \mathrm{f}$ roll-off frequency, thus the noise appears as a dc offset which gets cancelled.
The internal DAC uses binary weighted capacitors instead of the traditional R-2 R ladder type. This allows the AD7882 to employ a calibration routine that nulls the errors of the individual DAC segments along with offset and gain errors. Each segment of the capacitor DAC contains multiple capacitors that are used to trim for absolute accuracy. During a calibration routine, the DAC segments are compared against other segments and trimmed to $1 / 4$ LSB accuracy. Offset and gain errors are then calibrated either against the device AGND and $V_{\text {REFID }}$ inputs or external reference voltages that are applied at the $\mathrm{A}_{\mathrm{IN}}$ input.

## Calibration Routine +4

The AD7882 is capable of two calibration methods; system calibration and device calibration. Both modes calibrate the internal DAC linearity along with offset and gain errors. A system calibration is where the device calibrates its full scale and offset voltages against externally applied voltages. For a device calibration, full scale and offset are calibrated against the $\mathrm{V}_{\text {REFIN }}$ and AGND inputs. Note that a calibration must always be initiated after power on to meet the device performance specifications.
Calibration may be initiated in hardware by asserting the $\overline{\mathrm{CAL}}$ pin or in software by writing the appropriate word to the control register. The AD7882 will always perform a full calibration if initiated in hardware. However, under software control, partial calibration options including only offset and gain, can be performed. These options are shown in Table III.

## Device Calibration

Device calibration is initiated by pulsing $\overline{\mathrm{CAL}}$ low; see Figure 6. Offset and gain are calibrated against the AGND and $V_{\text {REFIN }}$ inputs respectively. This calibration procedure takes 928 ms , when using a 10 MHz clock.

## System Calibration

System calibration is initiated by a positive edge on $\overline{\mathrm{CAL}}$ as shown in Figure 7. $\overline{\text { BUSY }}$ goes low three times during the calibration procedure corresponding to the DAC, offset and gain calibrations respectively. The rising edge of the first BUSY pulse indicates that the DAC calibration is complete and the AD7882 is now ready to calibrate the offset. This is achieved by applying an external 0 V input at the $\mathrm{A}_{\mathrm{IN}}$ input and asserting the CONVST input. Note, the external 0 V input must be within $\pm 1.5 \%$ of AGND. The rising edge of the second $\overline{\text { BUSY }}$ pulse indicates that the part is ready to calibrate full scale. This time, the full scale input voltage must be applied to the analog input, and CONVST must be asserted once again. The full-scale input voltage must be within $\pm 1.5 \%$ of the reference input voltage. Complete calibration time is 928 ms plus the width of the two CONVST start pulses, when using a 10 MHz clock for the device.

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## Configuring the M/S Input

The M/S input with conjunction with the $\overline{\mathrm{CAL}}$ input determines the type of calibration initiated when CAL is taken low. It also determines whether the conversion is asynchronous (controlled by the CONVST input) or synchronous (with CLKIN). In all, they can be configured in four different ways as shown in Figure 11. The $\overline{\mathrm{CAL}}$ input is asserted by a positive edge, when calibration is required. Then, for example if synchronous operation and device calibration is required, M/S is tied to $\overline{\mathrm{CAL}}$. Note, an inverter can be used between the $\overline{\mathrm{CAL}}$ and the M/S inputs when asynchronous operation and system calibration is required.
If $\overline{\mathrm{CAL}}$ is high, then the user can start a Calibration from the Control Register.


Figure 11. M/S Input Configuration

## Timing and Control

Data communication with the AD7882 is controlled by four control inputs: $\overline{\mathrm{CS}}, \overline{\mathrm{RD}}, \overline{\mathrm{WR}}$ and ADD0. The data transfer consists of reading and writing to the control register or coefficients register and reading the conversion result from the output data register.

## Conversion Control and Data Reads

Conversion can be controlled in hardware by asserting the CONVST input (Asynchronous Mode) or the device can be set up for continuous "back-to-back" conversions (Synchronous Mode). The M/S input controls these as outlined above. In synchronous mode, a power-up, CAL or CONVST will initiate operation.

The data outputs are controlled by the $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ inputs. The possible timing configurations are shown in Figures 3, 4 and 5. If $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ are tied permanently low, then the data bus will always be active. However, it will change state at the end of conversion to reflect the most recent result. Reading the data bus must be avoided at this time.

## Control Register

The control register serves the dual function of providing control and monitoring the status of the AD7882. This register operation while ADD0 is high. One of the option settings in the control register is to set up the coefficients register for reading or writing. The coefficient registers contain the calibration coefficients. Loading the coefficients to the register consists of writing forty 16 -bit words. This activity is considerably shorter for almost any processor than performing a calibration. Thus, a typical application might read all the coefficients after calibration, store them in the backup memory and rewrite them to the AD7882 in future power-up initialization routines. Reading the calibration coefficients consists of forty read cycles to the AD7882. This will return forty 16 -bit words to the microprocessor.
Writing to the AD7882
Data can be written to either the control register or the coefficients register. A typical timing diagram is shown in Figure 12.


Figure 12. Typical Write Timing

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Table II. Control Register Bit Functions

| Bit Location | I/O Option | Power-Up <br> Default | Function |
| :---: | :---: | :---: | :---: |
| CR0 | Read Only | 0 | Conversion status. This bit is high during conversion. |
| CR1 | Read Only | 0 | Calibration status. This bit is high during calibration. |
| CR2 | Read/Write | $\mathrm{BIP} / \overline{\mathrm{UP}}$ | BIP/UP Select. Unipolar operation is selected when CR2 is 0 ; bipolar operation is selected when CR2 is 1 . This assumes that CR3 is 1 . When CR3 is $0, C R 2$ reflects the BIP/ $\overline{\mathrm{UP}}$ input. |
| CR3 | Read/Write | 0 | If CR3 $=1$, then Control Register bits CR2, CR9 and CR10 have priority. Otherwise external pins, $\overline{\text { SLEEP }}$ and BIP/ $\overline{\mathrm{UP}}$, have priority. |
| CR4 | Read/Write | 0 | CR4 to CR7 determine the calibration function, see Table III. |
| CR5 | Read/Write | 1 | Calibration function, See CR4. |
| CR6 | Read/Write | 1 | Calibration function, See CR4. |
| CR7 | Read/Write | 1 | Calibration function, See CR4. |
| CR8 |  |  | Not Used |
| CR9 | Read/Write | $\overline{\text { SLEEP }}$ | Sleep Control Bit. When CR3 is 1 , setting CR9 to 0 powers down all circuitry except the reference. When CR3 is 0, CR9 reflects the state of the $\overline{\text { SLEEP }}$ input. |
| CR10 | Read/Write | $\overline{\text { SLEEP }}$ | Reference power down. When CR3 is 1 , reference is powered by writing a 0 to CR10. When CR3 is 0, CR10 reflects the state of the SLEEP input. |
| CR11 | Read | 0 | A 1 in this location indicates an overflow on $A_{I N}$ in the last conversion and a gain adjust is required to bring the input back within range. |
| CR12 | Read | 0 | A 1 in this location indicates an underflow on $\mathrm{A}_{\mathrm{IN}}$ in the last conversion and a gain adjust is required to bring the input back within range. |
| CR13 |  |  | Not Used 4 , |
| CR14 | Read/Write | 0 | Status Bit. If this is 1 , it means that the calibration is halted. Calibration can be continued by writing a 0 to this location. |
| CR15 | Read/Write | 1 | Reset Bit. All memory and logic is reset when a 0 is written to this location. Reset happens on the rising edge of $\overline{\mathrm{WR}}$. If there is a subsequent control register read all bits except CR15 will have power-up default setting. Therefore, to restart after a software reset, it is necessary to write a 1 back into CR15. |

Table III. Calibration Options Using the Control Register

| CR7 | CR6 | CR5 | CR4 | Function |
| :--- | :--- | :--- | :--- | :--- |
| 0 | 0 | 0 | 0 | Normal Conversion, No Calibration |
| 0 | 0 | 0 | 1 | Normal Conversion, No Calibration |
| 0 | 0 | 1 | 0 | Gain Error Only-Device Calibration |
| 0 | 0 | 1 | 1 | Gain Error Only-System Calibration |
| 0 | 1 | 0 | 0 | Offset Error Only-Device Calibration |
| 0 | 1 | 0 | 1 | Offset Error Only-System Calibration |
| 0 | 1 | 1 | 0 | Offset and Gain Error Only-Device Calibration |
| 0 | 1 | 1 | 1 | Offset and Gain Error Only-System Calibration |
| 1 | 0 | 0 | 0 | Read All Calibration Coefficients |
| 1 | 0 | 0 | 1 | Write All Calibration Coefficients |
| 1 | 0 | 1 | 0 | Read Gain Calibration Coefficients Only |
| 1 | 0 | 1 | 1 | Write Gain Calibration Coefficients Only |
| 1 | 1 | 0 | 0 | Read Offset Calibration Coefficients Only |
| 1 | 1 | 0 | 1 | Write Offset Calibration Coefficients Only |
| 1 | 1 | 1 | 0 | Full Device Calibration |
| 1 | 1 | 1 | 1 | Full System Calibration |

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## FEATURES

Battery-Compatible Supply Voltage: Guaranteed Specs for $V_{D D}$ of 3 V to 3.6 V
12-Bit Monolithic A/D Converter
50 kHz Throughput Rate
$15 \mu \mathrm{~s}$ Conversion Time
$5 \mu \mathrm{Os}$ On-Chip Track/Hold Amplifier

## Low Power

Power Save Mode: 1 mW typ
Normal Operation: $8 \mathbf{m W}$ typ
70 dB SNR
Small 24-Lead SOIC and 0.3" DIP Packages

## APPLICATIONS

## Battery Powered Portable Systems

Laptop Computers

## GENERAL DESCRIPTION

The AD7883 is a high speed, low power, 12-bit A/D converter which operates from a single +3 V to +3.6 V supply. It consists of a $5 \mu \mathrm{~s}$ track/hold amplifier, a $15 \mu \mathrm{~s}$ successive-approximation ADC, versatile interface logic and a multiple-input-range circuit. The part also includes a power save feature.
Fast bus access times and standard control inputs ensure easy interfacing to modern microprocessors and digital signal processors.
The AD7883 features a total throughput time of $20 \mu \mathrm{~s}$ and can convert full power signals up to 25 kHz with a sampling frequency of 50 kHz .
In addition to the traditional dc accuracy specifications such as linearity, full-scale and offset errors, the AD7883 is also fully specified for dynamic performance parameters including harmonic distortion and signal-to-noise ratio.
The AD7883 is fabricated in Analog Devices' Linear Compatible CMOS (LC ${ }^{2}$ MOS) process, a mixed technology process that combines precision bipolar circuits with low power CMOS logic. The part is available in a 24 -pin, 0.3 inch-wide, plastic dual-inline package (DIP) as well as a small 24-lead SOIC package.

FUNCTIONAL BLOCK DIAGRAM


## PRODUCT HIGHLIGHTS

1. 3 V Operation

The AD7883 is guaranteed and tested with a supply voltage of 3 V to 3.6 V . This makes it ideal for battery-powered applications where 12 -bit A/D conversion is required.
2. Fast Conversion Time
$15 \mu \mathrm{~s}$ conversion time and $5 \mu \mathrm{~s}$ acquisition time allow for large input signal bandwidth. This performance is ideally suited for applications in areas such as telecommunications, audio, sonar and radar signal processing.
3. Low Power Consumption

1 mW power consumption in the power-down mode makes the part ideally suited for portable, hand held, battery powered applications.

This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

AD7883 - SPEGFIGATIONS $\left(V_{D D}=+3 V\right.$ to $+3.6 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}}=\mathrm{V}_{\mathrm{DD}}, A G N D=D G N D=0 \mathrm{~V}, \mathrm{f}_{\mathrm{CLKIN}}=2 \mathrm{MHz}$,
MODE $=$ Logic High. All specifications $T_{\text {mIN }}$ to $T_{\text {max }}$ unless otherwise noted.)

| Parameter | $B$ Versions ${ }^{1}$ | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: |
| DYNAMIC PERFORMANCE ${ }^{2}$ Signal-to-Noise Ratio ${ }^{3}$ (SNR) <br> Total Harmonic Distortion (THD) Peak Harmonic or Spurious Noise Intermodulation Distortion (IMD) Second Order Terms Third Order Terms | 69 <br> -80 <br> -80 <br>  <br> -80 <br> -80 | dB min <br> dB typ <br> dB typ <br> dB typ <br> dB typ | Typically SNR Is 71 dB <br> $\mathrm{V}_{\mathrm{IN}}=1 \mathrm{kHz}$ Sine Wave, $\mathrm{f}_{\text {SAMPLE }}=50 \mathrm{kHz}$ <br> $\mathrm{V}_{\text {IN }}=1 \mathrm{kHz}$ Sine Wave, $\mathrm{f}_{\text {SAMPLE }}=50 \mathrm{kHz}$ <br> $\mathrm{V}_{\mathrm{IN}}=1 \mathrm{kHz}, \mathrm{f}_{\mathrm{SAMPLE}}=50 \mathrm{kHz}$ $\begin{aligned} & \mathrm{fa}=0.983 \mathrm{kHz}, \mathrm{fb}=1.05 \mathrm{kHz}, \mathrm{f}_{\text {SAMPLE }}=50 \mathrm{kHz} \\ & \mathrm{fa}=0.983 \mathrm{kHz}, \mathrm{fb}=1.05 \mathrm{kHz}, \mathrm{f}_{\text {SAMPLE }}=50 \mathrm{kHz} \end{aligned}$ |
| DC ACCURACY <br> Resolution <br> Integral Nonlinearity Differential Nonlinearity Full-Scale Error Bipolar Zero Error Unipolar Offset Error | $\begin{aligned} & 12 \\ & \pm 2 \\ & \pm 1 \\ & \pm 20 \\ & \pm 12 \\ & \pm 3 \end{aligned}$ | Bits <br> LSB max <br> LSB max <br> LSB max <br> LSB max <br> LSB max | All DC ACCURACY Specifications Apply for the Two Analog Input Ranges <br> Guaranteed Monotonic |
| ANALOG INPUT Input Voltage Ranges Input Resistance | $\begin{aligned} & 0 \text { to } V_{\text {REF }} \\ & \pm V_{\text {REF }} \\ & 10 \\ & 5 / 12 \end{aligned}$ | Volts <br> Volts <br> $\mathrm{M} \Omega$ min <br> $k \Omega$ min/max | See Figure 4 <br> See Figure 5 <br> 0 to $\mathrm{V}_{\text {REF }}$ Range <br> $8 \mathrm{k} \Omega$ typical: $\pm \mathrm{V}_{\text {REF }}$ Range |
| REFERENCE INPUT <br> $\mathrm{V}_{\text {REF }}$ (For Specified Performance) $\mathrm{I}_{\text {REF }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}} \\ & 1.2 \end{aligned}$ | V $m A \max$ | - - |
| LOGIC INPUTS <br> $\overline{\text { CONVST }}, \overline{\text { RD }}, \overline{\mathrm{CS}}$, CLKIN <br> Input High Voltage, $\mathrm{V}_{\text {INH }}$ Input Low Voltage, $\mathrm{V}_{\text {INL }}$ Input Current, $\mathrm{I}_{\text {IN }}$ Input Capacitance, $\mathrm{C}_{\mathrm{IN}}{ }^{4}$ MODE INPUT Input High Voltage, $\mathrm{V}_{\text {INH }}$ Input Low Voltage, $\mathrm{V}_{\text {INL }}$ Input Current, $\mathrm{I}_{\mathrm{IN}}$ Input Capacitance, $\mathrm{C}_{\mathrm{IN}}{ }^{4}$ | $\begin{aligned} & 2.1 \\ & 0.6 \\ & \pm 10 \\ & 10 \\ & \mathrm{~V}_{\mathrm{DD}}-0.2 \\ & 0.2 \\ & \pm 100 \\ & 10 \end{aligned}$ | V min <br> V max $\mu \mathrm{A}$ max pF max <br> V <br> V <br> $\mu \mathrm{A}$ max pF max | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V} \text { or } \mathrm{V}_{\mathrm{DD}}$ $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V} \text { or } \mathrm{V}_{\mathrm{DD}}$ |
| LOGIC OUTPUTS <br> DB11-DB0, $\overline{\text { BUSY }}$ <br> Output High Voltage, $\mathrm{V}_{\mathrm{OH}}$ Output Low Voltage, $\mathrm{V}_{\mathrm{OL}}$ <br> DB11-DB0 <br> Floating-State Leakage Current Floating-State Output Capacitance ${ }^{4}$ | $\begin{aligned} & 2.4 \\ & 0.4 \\ & \pm 10 \\ & 10 \end{aligned}$ | V min <br> V max <br> $\mu \mathrm{A}$ max pF max | $\begin{aligned} & \mathrm{I}_{\text {SOURCE }}=200 \mu \mathrm{~A} \\ & \mathrm{I}_{\text {SINK }}=0.8 \mathrm{~mA} \end{aligned}$ |
| CONVERSION <br> Conversion Time Track/Hold Acquisition Time | $\begin{aligned} & 15 \\ & 5 \end{aligned}$ | $\mu \mathrm{s}$ max $\mu \mathrm{s}$ max | $\mathrm{f}_{\text {CLKIN }}=2 \mathrm{MHz}$ |
| POWER REQUIREMENTS <br> $V_{D D}$ <br> $\mathrm{I}_{\mathrm{DD}}$ <br> Normal Power Mode @ $+25^{\circ} \mathrm{C}$ <br> $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ <br> Power Save Mode @ $+25^{\circ} \mathrm{C}$ <br> $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ <br> Power Dissipation <br> Normal Power Mode @ $+25^{\circ} \mathrm{C}$ <br> $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\mathrm{MAX}}$ <br> Power Save Mode @ $+25^{\circ} \mathrm{C}$ <br> $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\mathrm{MAX}}$ | +3.3 3 4 400 800 11 15 1.5 3 | V nom <br> mA max mA max $\mu \mathrm{A}$ max $\mu \mathrm{A}$ max mW max mW max mW max mW max | +3 V to +3.6 V for Specified Performance <br> Typically $2 \mathrm{~mA} ;$ MODE $=\mathrm{V}_{\mathrm{DD}}$ <br> Typically $2.5 \mathrm{~mA} ;$ MODE $=\mathrm{V}_{\mathrm{DD}}$ <br> Logic Inputs @ 0 V or $\mathrm{V}_{\mathrm{DD}}$; MODE $=0 \mathrm{~V}$; Typically $250 \mu \mathrm{~A}$ <br> Logic Inputs @ 0 V or $\mathrm{V}_{\mathrm{DD}}$; MODE $=0 \mathrm{~V}$; Typically $300 \mu \mathrm{~A}$ <br> $\mathrm{V}_{\mathrm{DD}}=3.6 \mathrm{~V}$ : Typically 8 mW ; MODE $=\mathrm{V}_{\mathrm{DD}}$ <br> $\mathrm{V}_{\mathrm{DD}}=3.6 \mathrm{~V}$ : Typically 9 mW ; MODE $=\mathrm{V}_{\mathrm{DD}}$ <br> $\mathrm{V}_{\mathrm{DD}}=3.6 \mathrm{~V}$ : Typically $1 \mathrm{~mW} ;$ MODE $=0 \mathrm{~V}$ <br> $\mathrm{V}_{\mathrm{DD}}=3.6 \mathrm{~V}$ : Typically 1 mW ; $\mathrm{MODE}=0 \mathrm{~V}$ |

[^54]

| Parameter | Limit at $+25^{\circ} \mathrm{C}$ (All Versions) | Limit at $\mathbf{T}_{\text {MIN }}, \mathbf{T}_{\text {MAX }}$ (All Versions) | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{1}$ | 50 | 60 | ns min | CONVST Pulse Width |
| $\mathrm{t}_{2}$ | 200 | 200 | ns max | CONVST to BUSY Falling Edge |
| $\mathrm{t}_{3}$ | 0 | 0 | $n \mathrm{~ns}$ min | $\overline{\text { BUSY }}$ to $\overline{\mathrm{CS}}$ Setup Time |
| $\mathrm{t}_{4}$ | 0 | 0 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{RD}}$ Setup Time |
| $\mathrm{t}_{5}$ | 0 | 0 | $n \mathrm{n}$ min | $\overline{C S}$ to $\overline{R D}$ Hold Time |
| $\mathrm{t}_{6}$ | 110 | 150 | ns min | $\overline{\mathrm{RD}}$ Pulse Width |
| $\mathrm{t}_{7}{ }^{2}$ | 100 | 140 | ns max | Data Access Time after $\overline{\mathrm{RD}}$ |
| $\mathrm{t}_{8}{ }^{3}$ | 5 90 | $\begin{aligned} & 5 \\ & 90 \end{aligned}$ | ns $\min$ ns max | Bus Relinquish Time after $\overline{\mathrm{RD}}$ |

## NOTES

${ }^{1}$ Timing specifications in bold print are $100 \%$ production tested. All other times are sample tested at $25^{\circ} \mathrm{C}$ to ensure compliance. All input signals are specified with $\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of 5 V$)$ and timed from a voltage level of 1.6 V .
${ }^{2} t_{7}$, is measured with the load circuit of Figure 2 and defined as the time required for an output to cross 0.8 V or 2.4 V .
${ }^{3} \mathrm{t}_{8}$ is derived from the measured time taken by the data outputs to change by 0.5 V when loaded with the circuit of Figure 2 . The measured number is then extrapolated back to remove the effects of charging the 50 pF capacitor. This means that the time, $\mathrm{t}_{8}$, quoted in the timing characteristics is the true bus relinquish time of the part and as such is independent of external bus loading capacitances.


Figure 1. Timing Diagram


Figure 2. Load Circuit for Access and Relinquish Time

Table I. AD7883 Truth Table

| $\overline{\mathbf{C S}}$ | $\overline{\text { CONVST }}$ | $\overline{\mathbf{R D}}$ | Function |
| :--- | :--- | :--- | :--- |
| 1 | 1 | $\mathbf{X}$ | Not Selected |
| 1 | $\boxed{\boxed{S}}$ | 1 | Start Conversion $\Sigma$ |
| 0 | 1 | 0 | Enable ADC Data |
| 0 | 1 | 1 | Data Bus Three Stated |

## ORDERING GUIDE

| Model | Temperature Range | Package <br> Option |
| :--- | :--- | :--- |
| AD7883BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-24$ |
| AD7883BR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-24$ |

[^55]

PIN CONFIGURATION


## CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are removed.


## PIN FUNCTION DESCRIPTION

| Pin <br> No. | Pin <br> Mnemonic | Function |
| :---: | :---: | :---: |
| 1 | $\mathrm{V}_{\text {INA }}$ | Analog Input. |
| 2 | $V_{\text {INB }}$ | Analog Input. |
| 3 | AGND | Analog Ground. |
| 4 | $\mathrm{V}_{\text {REF }}$ | Voltage Reference Input. This is normally tied to $\mathrm{V}_{\mathrm{DD}}$. |
| 5 | $\overline{\mathrm{CS}}$ | Chip Select. Active Low Logic input. The device is selected when this input is active. |
| 6 | CONVST | Convert Start. A low to high transition on this input puts the track/hold into hold mode and starts conversion. This input is asynchronous to the CLKIN and is independent of $\overline{C S}$ and $\overline{R D}$. |
| 7 | $\overline{\mathrm{RD}}$ | Read. Active Low Logic Input. This input is used in conjunction with $\overline{\mathrm{CS}}$ low to enable data outputs. |
| 8 | $\overline{\text { BUSY }}$ | Active Low Logic Output. This status line indicates converter status. $\overline{\text { BUSY }}$ is low during conversion. |
| 9 | CLKIN | Clock Input. TTL-compatible logic input. Used as the clock source for the A/D converter. The mark/ space ratio of the clock can vary from $40 / 60$ to $60 / 40$. |
| 10 | DGND | Digital Ground. |
| $11 \ldots 22$ | DB0-DB11 | Three-State Data Outputs. These become active when $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ are brought low. |
| 23 | MODE | MODE Input. This input is used to put the device into the power save mode (MODE $=0 \mathrm{~V}$ ). During normal operation, the MODE input will be a logic high (MODE $=\mathrm{V}_{\mathrm{DD}}$ ). |
| 24 | $\mathrm{V}_{\text {DD }}$ | Power Supply. This is nominally +3.3 V . |

16-Bit, High Speed Sampling ADCs
AD7884/AD7885

## FEATURES

Monolithic Construction
Fast Conversion: $5.3 \mu \mathrm{~s}$
High Throughput: 166 kSPS
Low Power: $\mathbf{2 5 0} \mathbf{~ m W}$

## APPLICATIONS

Automatic Test Equipment
Medical Instrumentation
Industrial Control
Data Acquisition Systems
Robotics

## GENERAL DESCRIPTION

The AD7884/AD7885 is a 16 -bit monolithic analog-to-digital converter with internal sample-and-hold and a conversion time of $5.3 \mu \mathrm{~s}$. The maximum throughput rate is 166 kSPS . It uses a two pass flash architecture to achieve this speed. Two input ranges are available: $\pm 5 \mathrm{~V}$ and $\pm 3 \mathrm{~V}$. Conversion is initiated by the CONVST signal. The result can be read into a microprocessor using the $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ inputs on the device. The AD7884 has a 16-bit parallel reading structure while the AD7885 has a byte reading structure. The conversion result is in 2 s complement code.

The AD7884/AD7885 has its own internal oscillator which controls conversion. It runs from $\pm 5 \mathrm{~V}$ supplies and needs a $\mathrm{V}_{\mathrm{REF}+}$ of +3 V .

The AD7884 is available in a 40 -pin plastic DIP package and in a 44-pin PLCC package.

The AD7885 is available in a 28 -pin plastic DIP package and the AD7885A is available in a 44 -pin PLCC package.

FUNCTIONAL BLOCK DIAGRAMS


This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

AD7884/AD7885/AD7885A-SPECIFICATIONS ${ }_{v_{m}=+5 v+5 \%, v_{s}=-5 v \pm 5 \%}$
$\mathrm{V}_{\text {REF }} S=+3 \mathrm{~V}$; AGND $=\mathrm{DGND}=G N D=0 \mathbf{V} ; \mathrm{f}_{\text {SAMPLE }}=166 \mathrm{kHz}$. All specifications $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$, unless otherwise noted).

| Parameter | $\left\lvert\, \begin{array}{\|c} \mathbf{A} \\ \text { Version } \\ \\ \text { 1, 2, } \end{array}\right.$ | $\begin{array}{\|l\|} \mathbf{B} \\ \text { Version } \\ \text { 1, 2; } 3 \end{array}$ | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: |
| DC ACCURACY |  |  |  |  |
| Resolution | 16 | 16 | Bits |  |
| Minimum Resolution for Which |  |  |  |  |
| No Missing Codes Are Guaranteed | 16 | 16 | Bits |  |
| Integral Nonlinearity |  | $\pm 0.006$ | \% FSR max | Typically 0.003\% FSR |
| Positive Gain Error | $\pm 0.03$ | $\pm 0.03$ | \% FSR typ | AD7885AN/BN: 0.1\% typ |
| Positive Gain Error |  | $\pm 0.05$ | \% FSR max | AD7885BN: $0.2 \%$ max |
| Gain TC ${ }^{4}$ | $\pm 2$ | $\pm 2$ | ppm FSR/ $/{ }^{\circ} \mathrm{C}$ typ |  |
| Bipolar Zero Error | $\pm 0.05$ | $\pm 0.05$ | \% FSR typ | \% |
| Bipolar Zero Error |  | $\pm 0.15$ | \% FSR max |  |
| Bipolar Zero TC ${ }^{4}$ | $\pm 8$ | $\pm 8$ | ppm FSR/ $/{ }^{\circ} \mathrm{C}$ typ |  |
| Negative Gain Error | $\pm 0.03$ | $\pm 0.03$ | \% FSR typ | AD7885AN/BN: $0.1 \%$ typ |
| Negative Gain Error |  | $\pm 0.05$ | \% FSR max | AD7885BN: $0.2 \%$ max |
| Offset TC ${ }^{4}$ | $\pm 2$ | $\pm 2$ | ppm FSR/ $/{ }^{\circ} \mathrm{C}$ typ |  |
| Noise | 120 | 120 | $\mu \mathrm{V}$ rms typ | $78 \mu \mathrm{~V}$ rms typical in $\pm 3 \mathrm{~V}$ Input Range |
| DYNAMIC PERFORMANCE |  |  |  |  |
| Signal to (Noise + Distortion) Ratio | 84 | 84 | dB min | Input Signal: $\pm 5 \mathrm{~V}, 1 \mathrm{kHz}$ Sine Wave, Typically 86 dB |
|  | 82 | 82 | dB typ | Input Signal: $\pm 5 \mathrm{~V}, 12 \mathrm{kHz}$ Sine Wave |
| Total Harmonic Distortion | -88 | -88 | dB max | Input Signal: $\pm 5 \mathrm{~V}, 1 \mathrm{kHz}$ Sine Wave |
|  | -84 | -84 | dB typ | Input Signal: $\pm 5 \mathrm{~V}, 12 \mathrm{kHz}$ Sine Wave |
| Peak Harmonic or Spurious Noise | -88 | -88 | dB max | Input Signal: $\pm 5 \mathrm{~V}, 1 \mathrm{kHz}$ Sine Wave |
| Intermodulation Distortion (IMD) |  |  |  |  |
| 2nd Order Terms | -84 | -84 | dB typ | $\mathrm{f}_{\mathrm{A}}=11.5 \mathrm{kHz}, \mathrm{f}_{\mathrm{B}}=12 \mathrm{kHz}, \mathrm{f}_{\text {SAMPLE }}=166 \mathrm{kHz}$ |
| 3rd Order Terms | -84 | -84 | dB typ | $\mathrm{f}_{\mathrm{A}}=11.5 \mathrm{kHz}, \mathrm{f}_{\mathrm{B}}=12 \mathrm{kHz}, \mathrm{f}_{\text {SAMPLE }}=166 \mathrm{kHz}$ |
| CONVERSION TIME |  |  |  |  |
| Conversion Time | 5.3 | 5.3 | $\mu \mathrm{S}$ max |  |
| Acquisition Time | 2.5 | 2.5 | $\mu \mathrm{s}$ max |  |
| Throughput Rate | 166 | 166 | kSPS max | There is an overlap between conversion and acquisition. |
| ANALOG INPUT |  |  |  |  |
| Voltage Range | $\pm 5$ | $\pm 5$ | Volts | - |
|  | $\pm 3$ | $\pm 3$ | Volts | : - < |
| Input Current | $\pm 4$ | $\pm 4$ | mA max |  |
| REFERENCE INPUT <br> Reference Input Current | $\pm 5$ | $\pm 5$ | mA max |  |
| LOGIC INPUTS | $\pm 5$ |  | mA max | $\mathrm{VREF}^{+} \mathrm{S}=+3 \mathrm{~V}$ |
| Input High Voltage, $\mathrm{V}_{\text {INH }}$ | 2.4 | 2.4 | $V$ min | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \%$ |
| Input Low Voltage, $\mathrm{V}_{\text {INL }}$ | 0.8 | 0.8 | V max | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \%$ |
| Input Current, $\mathrm{I}_{\text {IN }}$ | $\pm 10$ | $\pm 10$ | $\mu \mathrm{A}$ max | Input Level $=0 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}$ |
| Input Capacitance, $\mathrm{C}_{\text {IN }}{ }^{4}$ | 10 | 10 | pF max |  |
| LOGIC OUTPUTS |  |  |  |  |
| Output High Voltage, $\mathrm{V}_{\mathrm{OH}}$ | 4.0 | 4.0 | V min | $\mathrm{I}_{\text {SOURCE }}=40 \mu \mathrm{~A}$ |
| Output Low Voltage, $\mathrm{V}_{\text {OL }}$ | 0.4 | 0.4 | V max | $\mathrm{I}_{\text {SINK }}=1.6 \mathrm{~mA}$ |
| DB15-DB0 |  |  |  |  |
| Floating-State Leakage Current | 10 | 10 | $\mu \mathrm{A}$ max |  |
| Floating-State Output Capacitance ${ }^{4}$ | 15 | 15 | pF max |  |
| POWER REQUIREMENTS |  |  |  |  |
| $\mathrm{V}_{\text {DD }}$ | +5 | +5 | V nom | $\pm 5 \%$ for Specified Performance |
| $\mathrm{V}_{\text {ss }}$ | -5 | -5 | V nom | $\pm 5 \%$ for Specified Performance |
| $\mathrm{I}_{\mathrm{DD}}$ | 35 | 35 | mA max | Typically 25 mA |
| $\mathrm{I}_{\text {ss }}$ | 30 | 30 | mA max | Typically 25 mA |
| Power Supply Rejection Ratio |  |  |  |  |
| $\Delta \mathrm{Gain} / \Delta \mathrm{V}_{\text {DD }}$ | 86 | 86 | dB typ |  |
| $\Delta \mathrm{Gain} / \Delta \mathrm{V}_{\text {ss }}$ | 86 | 86 | dB typ |  |
| Power Dissipation | 325 | 325 | mW max | Typically 250 mW |

[^56]TIMING CHARACTERISTICS ${ }^{1,2} \underset{\text { and } 5 .)}{\left(V_{D D}=\right.}+5 V \pm 5 \%, V_{S S}=-5 V \pm 5 \%$, AGND $=$ DGND $=G N D=0 V$. See Figures $2,3,4$

| Parameter | Limit at $+25^{\circ} \mathrm{C}$ <br> (All Versions) | Limit at $\mathrm{T}_{\text {MIN }}, \mathrm{T}_{\text {MAX }}$ (A, B Versions) | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{1}$ | 50 | 50 | ns min | CONVST Pulse Width |
| $\mathrm{t}_{2}$ | 100 | 100 | ns max | $\overline{\text { CONVST }}$ to BUSY Low Delay |
| $\mathrm{t}_{3}$ | 0 | 0 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{RD}}$ Setup Time |
| $\mathrm{t}_{4}$ | 60 | 60 | $n \mathrm{~ns}$ min | $\overline{\mathrm{RD}}$ Pulse Width |
| $\mathrm{t}_{5}$ | 0 | 0 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{RD}}$ Hold Time |
| $\mathrm{t}_{6}{ }^{2}$ | 57 | 57 | ns max | Data Access Time after $\overline{\mathrm{RD}}$ |
| $\mathrm{t}_{7}{ }^{3}$ | 5 | 5 | ns min | Bus Relinquish Time after $\overline{\mathrm{RD}}$ |
|  | 50 | 50 | ns max |  |
| $\mathrm{t}_{8}$ | 40 | 40 | ns min | New Data Valid before Rising Edge of $\overline{\text { BUSY }}$ |
| $\mathrm{t}_{9}$ | 10 | 80 | ns min | HBEN to $\overline{\mathrm{RD}}$ Setup Time |
| $\mathrm{t}_{10}$ | 25 | 25 | ns min | HBEN to $\overline{\mathrm{RD}}$ Hold Time |
| $\mathrm{t}_{11}$ | 60 | 60 | $n \mathrm{~ns}$ min | HBEN Low Pulse Duration |
| $\mathrm{t}_{12}$ | 60 | 60 | ns min | HBEN High Pulse Duration |
| $\mathrm{t}_{13}$ | 55 | 70 | ns max | Propagation Delay from HBEN Falling to Data Valid |
| $\mathrm{t}_{14}$ | 55 | 70 | ns max | Propagation Delay from HBEN Rising to Data Valid |

## NOTES

${ }^{1}$ Timing specifications in bold print are $100 \%$ production tested. All other times are sample tested at $+5^{\circ} \mathrm{C}$ to ensure compliance. All input signals are specified with $\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of 5 V$)$ and timed from a voltage level of 1.6 V .
${ }^{2} \mathrm{t}_{6}$ is measured with the load circuit of Figure 1 and defined as the time required for an output to cross 0.8 V or 2.4 V .
${ }^{3} \mathrm{t}_{7}$ is derived from the measured time taken by the data outputs to change 0.5 V when loaded with the circuit of Figure 1 . The measured number is then extrapolated back to remove the effects of charging or discharging the 100 pF capacitor. This means that the time, $\mathrm{t}_{7}$, quoted in the Timing Characteristics is the true bus relinquish time of the part and as such is independent of external bus loading capacitances.
Specifications subject to change without notice.

## ORDERING GUIDE

|  | Temperature <br> Range | Linearity <br> Error <br> (\% FSR) | SNR <br> (dB) | Package <br> Option |
| :--- | :--- | :--- | :--- | :--- |
| AD7884AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  | 84 | $\mathrm{~N}-40 \mathrm{~A}$ |
| AD7884BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 0.006$ | 84 | N-40A |
| AD7884AP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  | 84 | P-44A |
| AD7884BP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 0.006$ | 84 | P-44A |
| AD7885AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  | 84 | $\mathrm{~N}-28 \mathrm{~A}$ |
| AD7885BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 0.006$ | 84 | N-28A |
| AD7885ABP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  | 84 | P-44A |
| AD7885AAP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 0.006$ | 84 | P-44A |

## NOTES

${ }^{1}$ Analog Devices reserves the right to ship cerdip (Q) in lieu of plastic DIP. ${ }^{2} \mathrm{~N}=$ Plastic DIP; $\mathrm{P}=$ Plastic Leaded Chip Carrier (PLCC). For outline information see Package Information section.


Figure 1. Load Circuit for Access Time and Bus Relinquish Time

## AD7884/AD7885



Figure 2. AD7884 Timing Diagram, Using $\overline{C S}$ and $\overline{R D}$


Figure 3. AD7884 Timing Diagram, with $\overline{C S}$ and $\overline{R D}$ Permanently Low


Figure 4. AD7885 Timing Diagram, Using $\overline{C S}$ and $\overline{R D}$


Figure 5. AD7885 Timing Diagram, with $\overline{C S}$ and $\overline{R D}$ Permanently Low

| ABSOLUTE MAXIMUM RATINGS ${ }^{1}$ |  |
| :---: | :---: |
| $\mathrm{V}_{\text {DD }}$ to AGND | V to +7 V |
| $\mathrm{AV}_{\text {DD }}$ to AGND | -0.3 V to +7 V |
| $\mathrm{V}_{\text {ss }}$ to AGND | +0.3 V to -7 V |
| $\mathrm{AV}_{\text {SS }}$ to AGND | -0.3 V to -7 V |
| AGND Pins to DGND | -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| $A V_{D D}$ to $V_{D D}{ }^{2}$ | -0.3 V to +7 V |
| $\mathrm{AV}_{\text {ss }}$ to $\mathrm{V}_{\mathrm{ss}}{ }^{2}$ | +0.3 V to -7 V |
| GND to DGND | -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| $\mathrm{V}_{\text {IN }} \mathrm{S}, \mathrm{V}_{\text {IN }} \mathrm{F}$ to AGND | $\mathrm{V}_{\text {Ss }}-0.3 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| $\mathrm{V}_{\text {REF+ }}$ to AGND | $\mathrm{V}_{\text {ss }}-0.3 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| $\mathrm{V}_{\text {REF-- }}$ to AGND | $\mathrm{V}_{\text {Ss }}-0.3 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| $\mathrm{V}_{\text {INV }}$ to AGND | $\mathrm{V}_{\text {Ss }}-0.3 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| Digital Inputs to DGND | -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| Digital Outputs to DGND | -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |

Operating Temperature Range
Commercial Plastic (A, B Versions) . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Industrial Cerdip (A, B Versions) . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 secs) . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Power Dissipation (Any Package) to $+75^{\circ} \mathrm{C} \ldots . . .1000 \mathrm{~mW}$
Derates above $+75^{\circ} \mathrm{C}$ by . . . . . . . . . . . . . . . . . $10 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$
NOTES
${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. ${ }^{2}$ If the AD7884/AD7885 is being powered from separate analog and digital supplies, $\mathrm{AV}_{\text {ss }}$ should always come up before $\mathrm{V}_{\text {ss }}$. See Figure 13 for a recommended protection circuit using Schottky diodes.

## CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are removed.



## PLCC



PIN FUNCTION DESCRIPTION

| AD7884 | AD7885 | AD7885A | Description |
| :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {INV }}$ | $\mathrm{V}_{\text {INV }}$ | $\mathrm{V}_{\text {INV }}$ | This pin is connected to the inverting terminal of an op amp, as in Figure 6, and allows the inversion of the supplied +3 V reference. |
| $\mathrm{V}_{\text {REF- }}$ | $\mathrm{V}_{\text {REF- }}$ | $\mathrm{V}_{\text {REF - }}$ | This is the negative reference input, and it can be obtained by using an external amplifier to invert the positive reference input. In this case, the amplifier output is connected to $\mathrm{V}_{\mathrm{REF}}$ See Figure 6. |
| $\pm 3 \mathrm{~V}_{\mathrm{IN}} \mathrm{S}$ | - | $\pm 3 \mathrm{~V}_{\mathrm{IN}} \mathrm{S}$ | This is the analog input sense pin for the $\pm 3$ volt analog input range on the AD7884 and AD7885A. |
| $\pm 3 \mathrm{~V}_{\text {IN }} \mathrm{F}$ | - | $\pm 3 \mathrm{~V}_{\mathrm{IN}} \mathrm{F}$ | This is the analog input force pin for the $\pm 3$ volt analog input range on the AD7884 and AD7885A. When using this input range, the $\pm 5 \mathrm{~V}_{\mathrm{IN}} \mathrm{F}$ and $\pm 5 \mathrm{~V}_{\mathrm{IN}} \mathrm{S}$ pins should be tied to AGND. |
| - | $\pm 3 \mathrm{~V}_{\mathrm{IN}}$ | - | This is the analog input pin for the $\pm 3$ volt analog input range on the AD7885. When using this input range, the $\pm 5 \mathrm{~V}_{\mathrm{IN}} \mathrm{F}$ and $\pm 5 \mathrm{~V}_{\mathrm{IN}} \mathrm{S}$ pins should be tied to AGND. |
| $\pm 5 \mathrm{~V}_{\mathrm{IN}} \mathrm{S}$ | $\pm 5 \mathrm{~V}_{\mathrm{IN}} \mathrm{S}$ | $\pm 5 \mathrm{~V}_{\text {IN }} \mathrm{S}$ | This is the analog input sense pin for the $\pm 5$ volt analog input range on both the AD7884, AD7885 and AD7885A. |
| $\pm 5 \mathrm{~V}_{\mathrm{IN}} \mathrm{F}$ | $\pm 5 \mathrm{~V}_{\mathrm{IN}} \mathrm{F}$ | $\pm 5 \mathrm{~V}_{\mathrm{IN}} \mathrm{F}$ | This is the analog input force pin for the $\pm 5$ volt analog input range on both the AD7884, AD7885 and AD7885A. When using this input range, the $\pm 3 \mathrm{~V}_{\mathrm{IN}} \mathrm{F}$ and $\pm 3 \mathrm{~V}_{\mathrm{IN}} \mathrm{S}$ pins should be tied to AGND. |
| AGNDS | AGNDS | AGNDS | This is the ground return sense pin for the 9-bit ADC and the on-chip residue amplifier. |
| AGNDF | AGNDF | AGNDF | This is the ground return force pin for the 9-bit ADC and the on-chip residue amplifier. |
| $\mathrm{AV}_{\text {DD }}$ | $\mathrm{AV}_{\text {DD }}$ | $\mathrm{AV}_{\text {DD }}$ | Positive analog power rail for the sample-and-hold amplifier and the residue amplifier. |
| $\mathrm{AV}_{\text {Ss }}$ | $\mathrm{AV}_{\text {Ss }}$ | $\mathrm{AV}_{\text {Ss }}$ | Negative analog power rail for the sample-and-hold amplifier and the residue amplifier. |
| GND | GND | GND | This is the ground return for sample-and-hold section. |
| $\mathrm{V}_{\text {Ss }}$ | $\mathrm{V}_{\text {ss }}$ | $\mathrm{V}_{\text {ss }}$ | Negative supply for the 9-bit ADC. |
| $\mathrm{V}_{\text {DD }}$ | $\mathrm{V}_{\text {DD }}$ | $\mathrm{V}_{\text {DD }}$ | Positive supply for the 9-bit ADC and all device logic. |
| CONVST | CONVST | CONVST | This asynchronous control input starts conversion. |
| $\overline{\mathrm{CS}}$ | $\overline{\mathrm{CS}}$ | $\overline{\mathrm{CS}}$ | Chip Select control input. |
| $\overline{\mathrm{RD}}$ | $\overline{\mathrm{RD}}$ | $\overline{\mathrm{RD}}$ | Read control input. This is used in conjunction with $\overline{\mathrm{CS}}$ to read the conversion result from the device output latch. |
| - | HBEN | HBEN | High Byte Enable. Active high control input for the AD7885. It selects either the high or the low byte of the conversion for reading. |
| $\overline{\text { BUSY }}$ | $\overline{\text { BUSY }}$ | $\overline{\text { BUSY }}$ | Busy output. The Busy output goes low when conversion begins and stays low until it is completed, at which time it goes high. |
| DB0-DB15 | - | - | Sixteen-bit parallel data word output on the AD7884. |
| - | DB0-DB7 | DB0-DB7 | Eight-bit parallel data byte output on the AD7885. |
| DGND | DGND | DGND | Ground return for all device logic. |
| $\mathrm{V}_{\text {REF+ }+} \mathrm{F}$ | $\mathrm{V}_{\text {REF+ }} \mathrm{F}$ | $\mathrm{V}_{\mathrm{REF}+} \mathrm{F}$ | Reference force input. |
| $\underline{\mathrm{V}_{\text {REF+ }} \mathrm{S}}$ | $\mathrm{V}_{\mathrm{REF}+} \mathrm{S}$ | $\mathrm{V}_{\mathrm{REF}+} \mathrm{S}$ | Reference sense input. The device operates from a +3 V reference. |

## TERMINOLOGY

## Integral Nonlinearity

This is the maximum deviation from a straight line passing through the endpoints of the ADC transfer function.

## Differential Nonlinearity

This is the difference between the measured and the ideal 1 LSB change between any two adjacent codes in the ADC.

## Bipolar Zero Error

This is the deviation of the midscale transition (all 0 s to all 1s) from the ideal (AGND).

## Positive Gain Error

This is the deviation of the last code transition ( 01 . . 110 to 01 . . 111) from the ideal ( $+\mathrm{V}_{\mathrm{REF}+} \mathrm{S}-1 \mathrm{LSB}$ ), after Bipolar Zero Error has been adjusted out.

## Negative Gain Error

This is the deviation of the first code transition ( $10 \ldots 000$ to $10 \ldots 001$ ) from the ideal ( $-\mathrm{V}_{\mathrm{REF}+} \mathrm{S}+1 \mathrm{LSB}$ ), after Bipolar Zero Error has been adjusted out.

## Signal to (Noise + Distortion) Ratio

This is the measured ratio of signal to (noise + distortion) at the output of the A/D converter. The signal is the rms amplitude of the fundamental. Noise is the rms sum of all nonfundamental signals up to half the sampling frequency ( $\mathrm{f}_{\mathrm{S}} / 2$ ), excluding dc. The ratio is dependent upon the number of quantization levels in the digitization process; the more levels, the smaller the quantization noise. The theoretical signal to (noise + distortion) ratio for an ideal N -bit converter with a sine wave input is given by:

$$
\text { Signal to }(\text { Noise }+ \text { Distortion })=(6.02 N+1.76) d B
$$

Thus for an ideal 16-bit converter, this is 98 dB .

## Total Harmonic Distortion

Total harmonic distortion (THD) is the ratio of the rms sum of harmonics to the fundamental. For the AD7884/AD7885, it is defined as:

$$
T H D(d B)=20 \log \frac{\sqrt{V_{2}^{2}+V_{3}^{2}+V_{4}^{2}+V_{5}^{2}+V_{6}^{2}}}{V_{1}}
$$

where $V_{1}$ is the rms amplitude of the fundamental and $V_{2}, V_{3}$, $\mathrm{V}_{4}, \mathrm{~V}_{5}$ and $\mathrm{V}_{6}$ are the rms amplitudes of the second through the sixth harmonics.

## Peak Harmonic or Spurious Noise

Peak harmonic or spurious noise is defined as the ratio of the rms value of the next largest component in the ADC output spectrum (up to $\mathrm{f}_{\mathrm{s}} / 2$ and excluding dc) to the rms value of the fundamental. Normally, the value of this specification is determined by the largest harmonic in the spectrum, but for parts where the harmonics are buried in the noise floor, it will be a noise peak.

## Intermodulation Distortion

With inputs consisting of sine waves at two frequencies, fa and fb , any active device with nonlinearities will create distortion products at sum and difference frequencies of $\mathrm{mfa} \pm \mathrm{nfb}$ where $\mathrm{m}, \mathrm{n}=0,1,2,3$, etc. Intermodulation terms are those for which neither $m$ or $n$ are equal to zero. For example, the second order terms include ( $\mathrm{fa}+\mathrm{fb}$ ) and ( $\mathrm{fa}-\mathrm{fb}$ ), while the third order terms include $(2 f a+f b),(2 f a-f b),(f a+2 f b)$ and (fa-2fb).

The AD7884/AD7885 is tested using the CCIFF standard where two input frequencies near the top end of the input bandwidth are used. In this case, the second and third order terms are of different significance. The second order terms are usually distanced in frequency from the original sine waves while the third order terms are usually at a frequency close to the input frequencies. As a result, the second and third order terms are specified separately. The calculation of the intermodulation distortion is as per the THD specification where it is the ratio of the rms sum of the individual distortion products to the rms amplitude of the fundamental expressed in dBs.

## Power Supply Rejection Ratio

This is the ratio, in dBs , of the change in positive gain error to the change in $\mathrm{V}_{\mathrm{DD}}$ or $\mathrm{V}_{\mathrm{SS}}$. It is a dc measurement.

## OPERATIONAL DIAGRAM

An operational diagram for the AD7884/AD7885 is shown in Figure 6. It is set up for an analog input range of $\pm 5 \mathrm{~V}$. If a $\pm 3 \mathrm{~V}$ input range is required, Al should drive $\pm 3 \mathrm{~V}_{\mathrm{IN}} \mathrm{S}$ and $\pm 3 \mathrm{~V}_{\mathrm{IN}} \mathrm{F}$ with $\pm 5 \mathrm{~V}_{\mathrm{IN}} \mathrm{S}, \pm 5 \mathrm{~V}_{\mathrm{IN}} \mathrm{F}$ being tied to system AGND.


Figure 6. AD7884/AD7885 Operational Diagram
The chosen input buffer amplifier (A1) should have low noise and distortion and fast settling time for high bandwidth applications. Both the AD711 and the AD845 are suitable amplifiers.
A2 is the force, sense amplifier for AGND. The AGNDS pin should be at zero potential. Therefore, the amplifier must have a low input offset voltage and good noise performance. It must also have the ability to deal with fast current transients on the AGNDS pin. The AD817 has the required performance and is the recommended amplifier.
If AGNDS and AGNDF are simply tied together to Star Ground instead of buffering, the SNR and THD are not significantly degraded. However, dc specifications like INL, Bipolar Zero and Gain Error will be degraded.

## AD7884/AD7885

The required +3 V reference is derived from the AD780 and buffered by the high-speed amplifier A3 (AD845, AD817 or equivalent). A 4 is a unity gain inverter which provides the -3 V negative reference. The gain setting resistors are on-chip and are factory trimmed to ensure precise tracking of $\mathrm{V}_{\text {REF }+}$. Figure 6 shows A3 and A4 as AD845s or AD817s. These have the ability to respond to the rapidly changing reference input impedance.

## CIRCUIT DESCRIPTION

## Analog Input Section

The analog input section of the AD7884/AD7885 is shown in Figure 7. It contains both the input signal conditioning and sample-and-hold amplifier. Note that the analog input is truly benign. When SWla goes open circuit to put the SHA into the hold mode, SW1b is closed. This means that the input resistors, R1 and R2 are always connected to either virtual ground or true ground.


Figure 7. AD7884/AD7885 Analog Input Section
When the $\pm 3 \mathrm{~V}_{\mathrm{IN}} \mathrm{S}$ and $\pm 3 \mathrm{~V}_{\mathrm{IN}} \mathrm{F}$ inputs are tied to 0 V , the input section has a gain of -0.6 and transforms an input signal of $\pm 5$ volts to the required $\pm 3$ volts. When the $\pm 5 \mathrm{~V}_{\mathrm{IN}} \mathrm{S}$ and $\pm 5 \mathrm{~V}_{\mathrm{IN}} \mathrm{F}$ inputs are grounded, the input section has a gain of -1 and so the analog input range is now $\pm 3$ volts. Resistors R4 and R5, at the amplifier output, further condition the $\pm 3$ volts signal to be 0 to -3 volts. This is the required input for the 9-bit A/D converter section.
With SWla closed, the output of A1 follows the input (the sample-and-hold is in the track mode). On the rising edge of the CONVST pulse, SWla goes open circuit, and capacitor Cl holds the voltage on the output of A1. The sample-and-hold is now in the hold mode. The aperture delay time for the sample-and-hold is nominally 50 ns .

## A/D Converter Section

The AD7884/AD7885 uses a two-pass flash technique in order to achieve the required speed and resolution. When the CONVST control input goes from low to high, the sample-andhold amplifier goes into the hold mode and a 0 V to -3 V signal is presented to the input of the 9 -bit ADC. The first phase of conversion generates the 9 MSBs of the 16 -bit result and transfers these to the latch and ALU combination. They are also fed back to the 9 MSBs of the 16 -bit DAC. The 7 LSBs of the DAC are permanently loaded with 0 s. The DAC output is subtracted from the analog input with the result being amplified and offset in the Residue Amplifier Section. The signal at the output of A2 is proportional to the error between the first phase result and the actual analog input signal and is digitized in the second conversion phase. This second phase begins when the 16-bit DAC and the Residue Error Amplifier have both settled. First, SW2 is turned off and SW3 is turned on. Then, the SHA section of the Residue Amplifier goes into hold mode. Next SW2 is turned off and SW3 is turned on. The 9-bit result is transferred to the output latch and ALU. An error correction algorithm now compensates for the offset inserted in the Residue Amplifier Section and errors introduced in the first pass conversion and combines both results to give the 16 -bit answer.


Figure 8. $A / D$ Converter Section

## Timing and Control Section

Figure 9 shows the timing and control sequence for the AD7884/AD7885. When the part receives a CONVST pulse, the conversion begins. The input sample-and-hold goes into the hold mode 50 ns after the rising edge of $\overline{\text { CONVST }}$ and $\overline{\text { BUSY }}$ goes low. This is the first phase of conversion and takes $3.35 \mu \mathrm{~s}$ to complete. The second phase of conversion begins when SW2 is turned off and SW3 turned on. The Residue Amplifier and SHA section (A2 in Figure 8) goes into hold mode at this point and allows the input sample-and-hold to go back into sample mode. Thus, while the second phase of conversion is ongoing, the input sample-and-hold is also acquiring the input signal for the next conversion. This overlap between conversion and acquisition allows throughput rates of 166 kSPS to be achieved.


Figure 9. Timing and Control Sequence

## USING THE AD7884/AD7885

## Analog Input Ranges

The AD7884/AD7885 can be set up to have either a $\pm 3$ volts analog input range or a $\pm 5$ volts analog input range. Figures 10 and 11 show the necessary corrections for each of these. The output code is 2 s complement and the ideal code table for both input ranges is shown in Table I.

## Reference Considerations

The AD7884/AD7885 operates from a $\pm 3$ volt reference. This can be derived simply using the AD780 as shown in Figure 6.


Figure 10. $\pm 5$ V Input Range Connection


Figure 11. $\pm 3$ V Input Range Connections
The critical performance specification for a reference in a 16 -bit application is noise. The reference pk-pk noise should be insignificant in comparison to the ADC noise. The AD7884/AD7885 has a typical rms noise of $120 \mu \mathrm{~V}$. For example a reasonable target would be to keep the total rms noise less than $125 \mu \mathrm{~V}$. To do this the reference noise needs to be less than $35 \mu \mathrm{~V}$ rms. In the 100 kHz band, the AD780 noise is less than $30 \mu \mathrm{~V}$ rms, making it a very suitable reference.

The buffer amplifier used to drive the device $\mathrm{V}_{\text {REF }+}$ should have low enough noise performance so as not to affect the overall system noise requirement. The AD845 and AD817 achieve this.

Table I. Ideal Output Code Table for the AD7884/AD7885

| Analog Input |  |  | Digital Output <br> Code Transition ${ }^{1}$ |
| :---: | :---: | :---: | :---: |
| In Terms of FSR ${ }^{\mathbf{2}}$ | $\pm 3$ V Range ${ }^{3}$ | $\pm 5$ V Range ${ }^{4}$ |  |
| +FSR/2-1 LSB | 2.999908 | 4.999847 | 011 . . . 111 to 011 . . . 110 |
| +FSR/2-2 LSBs | 2.999817 | 4.999695 | 011 . . . 110 to $011 . . .101$ |
| +FSR/2-3LSBs | 2.999726 | 4.999543 | 011 . . . 101 to 011 . . . 100 |
| AGND + 1 LSB | 0.000092 | 0.000153 | $000 \ldots 001$ to $000 \ldots 000$ |
| AGND | 0.000000 | 0.000000 | 000 . . . 000 to $111 . \ldots 111$ |
| AGND - 1 LSB | -0.000092 | -0.000153 | 111. . 111 to 111. . . 110 |
| -(FSR/2-3 LSBs) | -2.999726 | -4.999543 | 100 . . 011 to $100 \ldots 010$ |
| -(FSR/2-2 LSBs) | -2.999817 | -4.999695 | 100 . . 010 to $100 \ldots 001$ |
| -(FSR/2-1 LSB) | -2.999908 | -4.999847 | 100 . . 001 to $100 \ldots 000$ |

## NOTES

${ }^{1}$ This table applies for $\mathrm{V}_{\text {REF }+} \mathrm{S}=+3 \mathrm{~V}$.
${ }^{2}$ FSR (Full-Scale Range) is 6 volts for the $\pm 3 \mathrm{~V}$ input range and 10 volts for the $\pm 5 \mathrm{~V}$ input range.
${ }^{3} 1 \mathrm{LSB}$ on the $\pm 3 \mathrm{~V}$ range is $\mathrm{FSR} / 2^{16}$ and is equal to $91.5 \mu \mathrm{~V}$.
${ }^{4} 1 \mathrm{LSB}$ on the $\pm 5 \mathrm{~V}$ range is $\mathrm{FSR} / 2^{16}$ and is equal to $152.6 \mu \mathrm{~V}$.

## AD7884/AD7885

## Decoupling and Grounding

The AD7884 and AD7885A have one $\mathrm{AV}_{\mathrm{DD}}$ pin and two $\mathrm{V}_{\mathrm{DD}}$ pins. They also have one $A V_{\text {ss }}$ pin and three $V_{\text {ss }}$ pins. The $A D 7885$ has one $A V_{D D}$ pin, one $V_{D D}$ pin, one $A V_{\text {Ss }}$ pin and one $V_{\text {Ss }}$ pin. Figure 6 shows how a common +5 V supply should be used for the positive supply pins and a common -5 V supply for the negative supply pins.
For decoupling purposes, the critical pins on both devices are the $A V_{D D}$ and $A V_{\text {ss }}$ pins. Each of these should be decoupled to system AGND with $10 \mu \mathrm{~F}$ tantalum and $0.1 \mu \mathrm{~F}$ ceramic capacitors right at the pins. With the $V_{D D}$ and $V_{S S}$ pins, it is sufficient to decouple each of these with ceramic $1 \mu \mathrm{~F}$ capacitors.
AGNDS, AGNDF are the ground return points for the on-chip 9 -bit ADC. They should be driven by a buffer amplifier as shown in Figure 6. If they are tied directly together and then to ground, there will be a marginal degradation in linearity performance.

The GND pin is the analog ground return for the on-chip linear circuitry. It should be connected to system analog ground.
The DGND pin is the ground return for the on-chip digital circuitry. It should be connected to the ground terminal of the $\mathrm{V}_{\mathrm{DD}}$ and $\mathrm{V}_{\mathrm{SS}}$ supplies. If a common analog supply is used for $A V_{D D}$ and $V_{D D}$ then DGND should be connected to the common ground point.

## Power Supply Sequencing

$A V_{D D}$ and $V_{D D}$ are connected to a common substrate and there is typically $17 \Omega$ resistance between them. If they are powered by separate +5 V supplies, then these should come up simultaneously. Otherwise, the one that comes up first will have to drive +5 V into a $17 \Omega$ load for a short period of time. However, the standard short-circuit protection on regulators like the 7800 series will ensure that there is no possibility of damage to the driving device.
$\mathrm{AV}_{\text {SS }}$ should always come up either before or at the same time as $\mathrm{V}_{\text {ss }}$. If this cannot be guaranteed, Schottky diodes should be used to ensure that $V_{\text {SS }}$ never exceeds $\mathrm{AV}_{\text {SS }}$ by more than 0.3 V . Arranging the power supplies as in Figure 6 and using the recommended decoupling ensures that there are no power supply sequencing issues as well as giving the specified noise performance.


Figure 12. Schottky Diodes Used to Protect Against Incorrect Power Supply Sequencing

## AD7884/AD7885 PERFORMANCE

## Linearity

The linearity of the AD7884/AD7885 is determined by the on-chip 16-bit D/A converter. This is a segmented DAC which is laser trimmed for 16 -bit DNL performance to ensure that there are no missing codes in the ADC transfer function. Figure 13 shows a typical INL plot for the AD7884/AD7885.


Figure 13. AD7884/AD7885 Typical Linearity Performance

## Noise

In an A/D converter, noise exhibits itself as code uncertainty in dc applications and as the noise floor (in an FFT, for example) in ac applications.

In a sampling A/D converter like the AD7884/AD7885, all information about the analog input appears in the baseband from dc to $1 / 2$ the sampling frequency. An antialiasing filter will remove unwanted signals above $\mathrm{f}_{\mathrm{S}} / 2$ in the input signal but the converter wideband noise will alias into the baseband. In the AD7884/AD7885, this noise is made up of sample-and-hold noise and a/d converter noise. The sample-and-hold section contributes $51 \mu \mathrm{~V}$ rms and the ADC section contributes $59 \mu \mathrm{~V}$ rms. These add up to a total rms noise of $78 \mu \mathrm{~V}$. This is the input referred noise in the $\pm 3 \mathrm{~V}$ analog input range. When operating in the $\pm 5 \mathrm{~V}$ input range, the input gain is. reduced to -0.6 . This means that the input referred noise is now increased by a factor of 1.66 to $120 \mu \mathrm{~V}$ rms.
Figure 14 shows a histogram plot for 5000 conversions of a dc input using the AD7884/AD7885 in the $\pm 5 \mathrm{~V}$ input range. The analog input was set as close as possible to the center of a code transition. All codes other than the center code are due to the ADC noise. In this case, the spread is six codes.


Figure 14. Histogram of 5000 Conversions of a DC Input

If the noise in the converter is too high for an application, it can be reduced by oversampling and digital filtering. This involves sampling the input at higher than the required word rate and then averaging to arrive at the final result. The very fast conversion time of the AD7884/AD7885 makes it very suitable for oversampling. For example, if the required input bandwidth is 40 kHz , the AD7884/AD7885 could be oversampled by a factor of 2 . This yields a 3 dB improvement in the effective SNR performance. The noise performance in the $\pm 5$ volt input range is now effectively $85 \mu \mathrm{~V}$ rms and the resultant spread of codes for 2500 conversions will be four. This is shown in Figure 15.


Figure 15. Histogram of 2500 Conversions of a DC Input Using a $\times 2$ Oversampling Ratio

## Dynamic Performance

With a combined conversion and acquisition time of $6 \mu \mathrm{~s}$, the AD7884/AD7885 is ideal for wide bandwidth signal processing applications. Signal to (Noise + Distortion), Total Harmonic Distortion, Peak Harmonic or Spurious Noise and Intermodulation Distortion are all specified. Figure 16 shows a typical FFT plot of a $1.8 \mathrm{kHz}, \pm 5 \mathrm{~V}$ input after being digitized by the AD7884/AD7885.


Figure 16. AD7884/AD7885 FFT Plot

## Effective Number of Bits

The formula for SNR (see Terminology Section) is related to the resolution or number of bits in the converter. Rewriting the formula, below, gives a measure of performance expressed in effective number of bits ( N ).


Figure 17. Effective Number of Bits vs. Frequency
The effective number of bits for a device can be calculated from its measured SNR. Figure 17 shows a typical plot of effective number of bits versus frequency for the AD7884. The sampling frequency is 166 kHz .

## MICROPROCESSOR INTERFACING

The AD7884/AD7885 is designed on a high speed process which results in very fast interfacing timing (Data Access Time of 57 ns max). The AD7884 has a full 16-bit parallel bus, and the AD7885 has an 8 -bit wide bus. The AD7884, with its parallel interface, is suited to 16 -bit parallel machines whereas the AD7885, with its byte interface, is suited to 8 -bit machines. Some examples of typical interface configurations follow.

## AD7884 to MC68000 Interface

Figure 18 shows a general interface diagram for the MC68000, 16-bit microprocessor to the AD7884. In Figure 18, conversion is initiated by bringing $\overline{\mathrm{CSA}}$ low (i.e., writing to the appropriate address). This allows the processor to maintain control over the complete conversion process. In some cases it may be more desirable to control conversion independent from the processor. This can be done by using an external sampling timer.


Figure 18. AD7884 to MC68000 Interface
Once conversion has been started, the processor must wait until it is completed before reading the result. There are two ways of ensuring this. The first way is to simply use a software delay to wait for $6.5 \mu$ before bringing $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ low to read the data.

The second way is to use the $\overline{\text { BUSY }}$ output of the AD7884 to generate an interrupt in the MC68000. Because of the nature of its interrupts, the MC68000 requires additional logic (not shown in Figure 18) to allow it to be interrupted correctly. For full information on this, consult the MC68000 User's Manual.

## AD7885 to 8088 Interface

The AD7885, with its byte $(8+8)$ data format, is ideal for use with the 8088 microprocessor. Figure 19 is the interface diagram. Conversion is started by enabling $\overline{\mathrm{CSA}}$. At the end of conversion, data is read into the processor. The read instructions are:

$$
\begin{array}{ll}
\text { MOV AX, C001 } & \text { Read } 8 \text { MSBs of data } \\
\text { MOV AX, C000 } & \text { Read } 8 \text { LSBs of data }
\end{array}
$$



Figure 19. AD7885 to 8088 Interface

## AD7884 to ADSP-2101 Interface

Figure 20 shows an interface between the AD7884 and the ADSP-2101. Conversion is initiated using a timer which allows very accurate control of the sampling instant. The AD7884 $\overline{\text { BUSY }}$ line provides an interrupt to the ADSP-2101 when conversion is completed. The $\overline{\mathrm{RD}}$ pulse width of the processor can be programmed using the Data Memory Wait State Control Register. The result can then be read from the ADC using the following instruction:

$$
\mathrm{MR} 0=\mathrm{DM}(\mathrm{ADC})
$$

where MR0 is the ADSP-2101 MR0 register, and ADC is the AD7884 address.

Figure 20. AD7884 to ADSP-2101 Interface


## Stand-Alone Operation

If $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ are tied permanently low on the AD7884, then, when a conversion is completed, output data will be valid on the rising edge of BUSY. This makes the device very suitable for stand-alone operation. All that is required to run the device is an external CONVST pulse which can be supplied by a sample timer. Figure 21 shows the AD7884 set up in this mode with the $\overline{\text { BUSY }}$ signal providing the clock for the 74 HC 574 3-state latches.


Figure 21. Stand-Alone Operation

Digital Feedthrough from an Active Bus
It is very important when using the AD7884/AD7885 in a microprocessor-based system to isolate the ADC data bus from the active processor bus while a conversion is being executed. This will yield the best noise performance from the ADC. Latches like the 74 HC 574 can be used to do this. If the device is connected directly to an active bus then the converter noise will typically increase by a factor of $30 \%$.

## FEATURES

750 kHz/1 MHz Throughput Rate $1 \mu \mathrm{~s} / 750 \mathrm{~ns}$ Conversion Time 12-Bit No Missed Codes Over Temperature 67 dB SNR at 100 kHz Input Frequency Low Power-250 mW typ<br>Fast Bus Access Time-57 ns max

APPLICATIONS<br>Digital Signal Processing Speech Recognition and Synthesis Spectrum Analysis<br>DSP Servo Control

## GENERAL DESCRIPTION

The AD7886 is 12-bit ADC with a sample-and-hold amplifier offering high speed performance combined with low power dissipation. The AD7886 is a triple pass flash ADC, which uses 15 comparators in a 4-bit flash technique to achieve 12-bit accuracy in $1 \mu \mathrm{~s} / 750 \mathrm{~ns}$ conversion time. An on-chip clock oscillator provides the appropriate timing for each of the three conversion stages eliminating the need for any external clocks. Acquisition time of the sample-and-hold amplifier gives a resulting throughput rate of $750 \mathrm{kHz} / 1 \mathrm{MHz}$.*

The AD7886 operates from $\pm 5$ V power supplies. Pinstrappable inputs offer a choice of three analog input ranges; 0 to $5 \mathrm{~V}, 0$ to 10 V or $\pm 5 \mathrm{~V}$.

In addition to the traditional dc accuracy specifications such as linearity, offset and full-scale errors, the AD7886 is also specified for dynamic performance parameters including harmonic distortion and signal-to-noise ratio.
The AD7886 has a high speed digital interface with three-state data outputs. Conversion control is provided by a CONVST input. Data access is controlled by $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ inputs, standard microprocessor signals. The data access time of less than 57 ns means that the AD7886 can interface directly to most modern microprocessors including DSP processors.

[^57]FUNCTIONAL BLOCK DIAGRAM

## PRODUCT HIGHLIGHTS

1. Fast $1.33 \mu \mathrm{~s} / 1 \mu \mathrm{~s}$ Throughput Time. Fast throughput time makes the AD7886 suitable for a wide range of data acquisition applications.
2. Dynamic Specifications for DSP Users.

The AD7886 is specified for ac parameters, including signal-to-noise ratio, harmonic distortion and intermodulation distortion. Key digital timing parameters are also tested and guaranteed over the full operating temperature range.
3. Fast Microprocessor Interface.

Standard control signals, $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$, and fast bus access times make the AD7886 easy to interface to microprocessors.
4. Low Power.

LC $^{2}$ MOS fabrication process gives low power dissipation of 250 mW .

The AD7886 is fabricated in Analog Devices' Linear Compatible CMOS process, a mixed technology process that combines precision bipolar circuits with low power CMOS logic.

The AD7886 is available in both a 28 -pin DIP and in a 28 -pin leaded chip carrier.

$V_{D D}=+5 \mathrm{~V} \pm 5 \%, V_{S S}=-5 \mathrm{~V} \pm 5 \%$, AGND $=$ DGND $=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}}=-3.5 \mathrm{~V}$,
AD7886 SPECIFICATIONS
connected as shown in Figure 2. All Specifications $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ uniess otherwise noted. Specifications apply for 750 kHz version.)

\begin{tabular}{|c|c|c|c|c|c|}
\hline Parameter \& J Version \({ }^{1}\) \& K, B Versions \({ }^{1}\) \& T Version \({ }^{1}\) \& Units \& Test Conditions/Comments \\
\hline \begin{tabular}{l}
DYNAMIC PERFORMANCE \({ }^{2}\) \\
Signal-to-Noise Ratio \({ }^{3}\) (SNR) \\
Total Harmonic Distortion (THD) \\
Peak Harmonic or Spurious Noise Intermodulation Distortion (IMD) Second Order Terms Third Order Terms
\end{tabular} \& 65
-75
-77

-80

-80 \& $$
\begin{aligned}
& 67 \\
& -75 \\
& -77 \\
& \\
& -80 \\
& -80
\end{aligned}
$$ \& \[

$$
\begin{aligned}
& 65 \\
& -75 \\
& -77 \\
& \\
& -80 \\
& -80
\end{aligned}
$$

\] \& dB min dB typ dB typ dB typ dB typ \& | VIN $=100 \mathrm{kHz}$ Sine Wave, $\mathrm{f}_{\text {SAMPLE }}=750 \mathrm{kHz}$ |
| :--- |
| VIN $=100 \mathrm{kHz}$ Sine $W_{\text {ave }}, \mathrm{f}_{\text {SAMPLE }}=750 \mathrm{kHz}$ |
| VIN $=100 \mathrm{kHz}$ Sine Wave, $\mathrm{f}_{\text {SAMPLE }}=750 \mathrm{kHz}$ $\mathrm{f}_{\mathrm{a}}=96 \mathrm{kHz}, \mathrm{f}_{\mathrm{b}}=103 \mathrm{kHz}, \mathrm{f}_{\text {SAMPLE }}=750 \mathrm{kHz}$ | <br>

\hline ```
ACCURACY
Resolution
Integral Linearity $T_{\text {min }}$ to $T_{\text {max }}$
Minimum Resolution for Which
No Missing Codes Are Guaranteed
Unipolar Offset Error @ $+25^{\circ} \mathrm{C}$
$\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$
Bipolar Offset Error @ $+25^{\circ} \mathrm{C}$
$T_{\text {min }}$ to $T_{\text {max }}$
Unipolar Gain Error @ $+25^{\circ} \mathrm{C}$
$T_{\text {min }}$ to $T_{\text {max }}$
Bipolar Gain Error @ $+25^{\circ} \mathrm{C}$
$T_{\text {min }}$ to $T_{\text {max }}$

``` & \begin{tabular}{l}
12 \\
12 \\
\(\pm 5\) \\
\(\pm 5\) \\
\(\pm 5\) \\
\(\pm 5\) \\
\(\pm 5\) \\
\(\pm 5\) \\
\(\pm 5\) \\
\(\pm 5\)
\end{tabular} & \[
\begin{aligned}
& 12 \\
& \pm 2 \\
& 12 \\
& \pm 5 \\
& \pm 5 \\
& \pm 5 \\
& \pm 5 \\
& \pm 5 \\
& \pm 5 \\
& \pm 5 \\
& \pm 5
\end{aligned}
\] & \[
\begin{aligned}
& 12 \\
& \pm 2 \\
& 12 \\
& \pm 5 \\
& \pm 5 \\
& \pm 5 \\
& \pm 5 \\
& \pm 5 \\
& \pm 5 \\
& \pm 5 \\
& \pm 5
\end{aligned}
\] & \begin{tabular}{l}
Bits \\
LSB max \\
Bits \\
LSB max \\
LSB max \\
LSB max \\
LSB max \\
LSB max \\
LSB max \\
LSB max \\
LSB max
\end{tabular} & \begin{tabular}{l}
Input Range: 0 to 5 V or 0 to 10 V \\
Input Range: \(\pm 5 \mathrm{~V}\) \\
Input Range: 0 to 5 V or 0 to 10 V \\
Input Range: \(\pm 5 \mathrm{~V}\)
\end{tabular} \\
\hline ANALOG INPUT Unipolar Input Current Bipolar Input Current & \[
\begin{aligned}
& 1.5 \\
& \pm 0.75
\end{aligned}
\] & \[
\begin{aligned}
& 1.5 \\
& \pm 0.75
\end{aligned}
\] & \[
\begin{aligned}
& 1.5 \\
& \pm 0.75
\end{aligned}
\] & \(m A \max\) mA max & \begin{tabular}{l}
Input Ranges: 0 to 5 V or 0 to 10 V \\
Input Range: \(\pm 5 \mathrm{~V}\)
\end{tabular} \\
\hline \begin{tabular}{l}
REFERENCE INPUT \\
\(V_{\text {ReF }}\) \\
Input Reference Current \\
R1, Resistance \\
R2, Resistance \\
R2/R1 Ratio
\end{tabular} & \[
\begin{aligned}
& -3.5 \\
& -10 \\
& 9 \\
& 6.3 \\
& 0.7
\end{aligned}
\] & \[
\begin{aligned}
& -3.5 \\
& -10 \\
& 9 \\
& 6.3 \\
& 0.7
\end{aligned}
\] & \[
\begin{aligned}
& -3.5 \\
& -10 \\
& 9 \\
& 6.3 \\
& 0.7
\end{aligned}
\] & Volts mA max \(\mathrm{k} \Omega\) nom \(\mathrm{k} \Omega\) nom nom & \(\pm 2 \%\) For Specified Performance
\[
\begin{aligned}
& \pm 25 \% \\
& \pm 25 \% \\
& \pm 0.1 \%
\end{aligned}
\] \\
\hline \begin{tabular}{l}
POWER SUPPLY REJECTION \\
\(V_{\text {DD }}\) Only, (FS Change) \\
\(V_{\text {ss }}\) Only, (FS Change)
\end{tabular} & \[
\begin{aligned}
& 0.5 \\
& 0.5
\end{aligned}
\] & & \[
\begin{aligned}
& 0.5 \\
& 0.5
\end{aligned}
\] & \[
\begin{aligned}
& \text { LSB typ } \\
& \text { LSB typ }
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{ss}}=-5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=+4.75 \mathrm{~V} \text { to }+5.25 \mathrm{~V} \\
& \mathrm{~V}_{\mathrm{DD}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{ss}}=-4.75 \mathrm{~V} \text { to }-5.25 \mathrm{~V}
\end{aligned}
\] \\
\hline LOGIC INPUTS Input High Voltage, \(\mathrm{V}_{\text {INH }}\) Input Low Voltage, \(\mathrm{V}_{\text {INL }}\) Input Current, \(\mathrm{I}_{\mathrm{IN}}\) Input Capacitance, \(\mathrm{C}_{\mathrm{IN}}{ }^{4}\) & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 10 \\
& 10
\end{aligned}
\] & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 10 \\
& 10
\end{aligned}
\] & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 10 \\
& 10
\end{aligned}
\] & \begin{tabular}{l}
V min \\
V max \\
\(\mu \mathrm{A}\) max \\
pF max
\end{tabular} & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \% \\
& \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \% \\
& \mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{DD}}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
LOGIC OUTPUTS \\
DB11-DB0, \(\overline{\text { BUSY }}\) \\
Output High Voltage, \(\mathrm{V}_{\mathrm{OH}}\) \\
Output Low Voltage, \(\mathrm{V}_{\text {ol }}\) \\
DB11-DB0 \\
Floating-State Leakage Current Floating-State Output Capacitance \({ }^{4}\)
\end{tabular} & \[
\begin{array}{|l}
4 \\
0.4 \\
\\
\pm 10 \\
15
\end{array}
\] & \[
\begin{aligned}
& 4 \\
& 0.4 \\
& \pm 10 \\
& 15
\end{aligned}
\] & \[
\begin{aligned}
& 4 \\
& 0.4 \\
& \\
& \pm 10 \\
& 15
\end{aligned}
\] & \begin{tabular}{l}
V min \\
V max \\
\(\mu \mathrm{A}\) max pF max
\end{tabular} & \[
\begin{aligned}
& I_{\text {SOURCE }}=200 \mu \mathrm{~A} \\
& \mathrm{I}_{\text {SINK }}=1.6 \mathrm{~mA}
\end{aligned}
\] \\
\hline ```
POWER REQUIREMENTS
    VDD
    Vs
    I
    I
    Power Dissipation
``` & \[
\begin{aligned}
& +5 \\
& -5 \\
& 35 \\
& -35 \\
& 250 \\
& 350
\end{aligned}
\] & \[
\begin{aligned}
& +5 \\
& -5 \\
& 35 \\
& -35 \\
& 250 \\
& 350
\end{aligned}
\] & \[
\begin{aligned}
& +5 \\
& -5 \\
& 35 \\
& -35 \\
& 250 \\
& 350
\end{aligned}
\] & \begin{tabular}{l}
V nom \\
V nom \\
mA max \\
mA max \\
mW typ \\
mW max
\end{tabular} & \begin{tabular}{l}
\(\pm 5 \%\) for Specified Performance \\
\(\pm 5 \%\) for Specified Performance \\
Typically \(25 \mathrm{~mA}, \overline{\mathrm{CONVST}}=\overline{\mathbf{C S}}=\overline{\mathbf{R D}}=\mathrm{V}_{\mathrm{DD}}\) \\
Typically \(25 \mathrm{~mA}, \overline{\mathrm{CONVST}}=\overline{\mathbf{C S}}=\overline{\mathbf{R D}}=\mathrm{V}_{\mathrm{DD}}\)
\[
\overline{\text { CONVST }}=\overline{\mathbf{C S}}=\overline{\mathbf{R D}}=\mathrm{V}_{\mathrm{DD}}
\]
\end{tabular} \\
\hline
\end{tabular}

\footnotetext{
NOTES
\({ }^{1}\) Temperature ranges are as follows: \(\mathrm{J}, \mathrm{K}\) Versions: \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\); B Version: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\); T Version: \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\).
\({ }^{2}\) Applies to all three input ranges, VIN \(=0\) to FS, pk-to-pk V.
\({ }^{3}\) SNR calculation includes distortion and noise components.
\({ }^{4}\) Sample tested \(@+25^{\circ} \mathrm{C}\) to ensure compliance.
Specifications subject to change without notice.
}

TIMING CHARACTERISTICS \({ }^{1}\) \(\left(V_{D D}=+5 V \pm 5 \%, V_{S S}=-5 V \pm 5 \%, A G N D=D G N D=0 V\right)\)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Parameter & \begin{tabular}{l}
Limit at \(T_{\text {min }}, T_{\text {max }}\) \\
(J, K Versions)
\end{tabular} & \begin{tabular}{l}
Limit at \(\mathbf{T}_{\text {min }}, \mathrm{T}_{\text {max }}\) \\
(B Version)
\end{tabular} & \begin{tabular}{l}
Limit at \(T_{\text {min }}, T_{\text {max }}\) \\
(T Version)
\end{tabular} & Units & Conditions/Comments \\
\hline \multirow[t]{2}{*}{\(\mathrm{t}_{1}\)} & 50 & 50 & 50 & ns min & \multirow[t]{2}{*}{CONVST Pulse Width} \\
\hline & 1 & 1 & 1 & \(\mu s\) max & \\
\hline \(\mathrm{t}_{2}\) & 0 & 0 & 0 & ns min & \(\overline{\mathrm{CS}}\) to \(\overline{\mathrm{RD}}\) Setup Time \\
\hline \(\mathrm{t}_{3}\) & 0 & 0 & 0 & ns min & \(\overline{\mathrm{CS}}\) to \(\overline{\mathrm{RD}}\) Hold Time \\
\hline \(\mathrm{t}_{4}\) & 60 & 60 & 75 & ns min & \(\overline{\mathrm{RD}}\) Pulse Width \\
\hline \(\mathrm{t}_{5}\) & 100 & 100 & 100 & ns max & \(\overline{\text { CONVST }}\) to \(\overline{\text { BUSY }}\) Propagation Delay, \(\left(\mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}\right)\) \\
\hline \(\mathrm{t}_{6}{ }^{2}\) & 57 & 57 & 70 & ns max & Data Access Time After \(\overline{\mathrm{RD}}\) \\
\hline \multirow[t]{2}{*}{\(\mathrm{t}_{7}{ }^{3}\)} & 10 & 10 & 10 & ns min & \multirow[t]{2}{*}{Bus Relinquish Time After \(\overline{\mathrm{RD}}\)} \\
\hline & 50 & 50 & 60 & ns max & \\
\hline \multirow[t]{2}{*}{\(\mathrm{t}_{8}\)} & 20 & 20 & 14 & ns min & \multirow[t]{2}{*}{Data Setup Time Prior to \(\overline{\text { BUSY }},\left(\mathrm{C}_{\mathrm{L}}=20 \mathrm{pF}\right)\) Data Setup Time Prior to \(\overline{B U S Y},\left(C_{L}=100 \mathrm{pF}\right)\)} \\
\hline & 10 & 10 & 0 & ns min & \\
\hline \multirow[t]{2}{*}{\(\mathrm{t}_{9}{ }^{3}\)} & 10 & 10 & 10 & ns min & \multirow[t]{2}{*}{Bus Relinquish Time After CONVST} \\
\hline & 100 & 100 & 100 & ns max & \\
\hline \(\mathrm{t}_{10}\) & 0 & 0 & 0 & ns min & \(\overline{\text { CS }}\) High to CONVST Low \\
\hline \(\mathrm{t}_{11}\) & 0 & 0 & 0 & ns min & \(\overline{\text { BUSY }}\) High to \(\overline{\text { RD }}\) Low \\
\hline \(\mathrm{t}_{12}\) & 250 & 250 & 250 & ns typ & \(\overline{\text { BUSY }}\) High to CONVST Low, SHA Acquisition Time \\
\hline \(\mathrm{t}_{13}\) & 1.333 & 1.333 & 1.333 & \(\mu \mathrm{s}\) min & Sampling Interval \\
\hline \(\mathrm{t}_{\text {CONV }}\) & \[
\begin{aligned}
& 950 \\
& 1000
\end{aligned}
\] & \[
\begin{aligned}
& 950 \\
& 1000
\end{aligned}
\] & \[
\begin{aligned}
& 950 \\
& 1000
\end{aligned}
\] & ns typ ns max & Conversion Time \\
\hline
\end{tabular}

NOTES
\({ }^{1}\) Timing specifications in bold print are \(100 \%\) production tested. All other times are sample tested at \(+25^{\circ} \mathrm{C}\) to ensure compliance. All input signals are specified with \(\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%\) to \(90 \%\) of 5 V\()\) and timed from a voltage level of 1.6 V .
\({ }^{2} \mathrm{t}_{6}\) is measured with the load circuit of Figure 1 and defined as the time required for an output to cross 0.8 V or 2.4 V .
\({ }^{3} t_{7}\) and \(t_{9}\) are derived from the measured time taken by the data outputs to change by 0.5 V when loaded with the circuit of Figure 1 . The measured number is then extrapolated back to remove the effects of charging or discharging the load capacitor, \(C_{L}\). This means that the times, \(t_{7}\) and \(t_{9}\), quoted in the timing characteristics are the true bus relinquish times of the part and as such are independent of external bus loading capacitances.
Specifications subject to change without notice.


Figure 1. Load Circuit for Bus Access and Relinquish Time ABSOLUTE MAXIMUM RATINGS \({ }^{\mathbf{1}, 2}\)
( \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) unless otherwise noted)
\(\mathrm{V}_{\mathrm{DD}}\) to AGND . . . . . . . . . . . . . . . . . . -0.3 V to +7 V
\(\mathrm{V}_{\text {ss }}\) to AGND . . . . . . . . . . . . . . . . . . . . . +0.3 V to -7 V
AGND to DGND . . . . . . . . . . . . -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)

VIN1, VIN2, SUM, +5REF to AGND . . . - 15 V to +15 V \(\mathrm{V}_{\text {REF }}\) to AGND . . . . . . . . . . \(\mathrm{V}_{\text {Ss }}-0.3 \mathrm{~V}\) to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\) Digital Inputs to DGND
\[
\overline{\mathrm{CS}}, \overline{\mathrm{RD}}, \overline{\mathrm{CONVST}} \ldots \ldots . .
\]

Digital Outputs to DGND
 Operating Temperature Range

Commercial (J, K Versions) . . . . . . . . . . . . . \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\)
Industrial (B Version) . . . . . . . . . . . . . . . \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
Extended (T Version) . . . . . . . . . . . . . . \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
Storage Temperature Range . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Lead Temperature (Soldering, 10 secs) . . . . . . . . . . . \(+300^{\circ} \mathrm{C}\)
Power Dissipation (Any Package) to \(+75^{\circ} \mathrm{C}\). . . . . . 1000 mW
Derates above \(+75^{\circ} \mathrm{C}\) by . . . . . . . . . . . . . . . . . \(10 \mathrm{~mW} /{ }^{\circ} \mathrm{C}\) NOTES
\({ }^{1}\) Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. \({ }^{2}\) If \(V_{\text {Ss }}\) is open circuited with \(V_{D D}\) and AGND applied, the \(V_{\text {sS }}\) pin will be pulled positive, exceeding the Absolute Maximum Ratings. If this possibility exists, a Schottky diode from \(\mathrm{V}_{\text {Ss }}\) to DGND (cathode end to GND) ensures that the Absolute Maximum Ratings will be observed.

\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are inserted.


ORDERING GUIDE
\begin{tabular}{l|l|l|l|l}
\hline & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
SNR \\
(dBs)
\end{tabular} & \begin{tabular}{l} 
Integral \\
Nonlinearity \\
(LSBs)
\end{tabular} & \begin{tabular}{l} 
Package \\
Option \({ }^{3}\)
\end{tabular} \\
\hline AD7886JD & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & 65 & & \begin{tabular}{l}
\(\mathrm{D}-28\) \\
AD7886KD \\
\(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\)
\end{tabular} \\
AD78865J & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & 65 & \(\pm 2.0\) & \(\mathrm{D}-28\) \\
AD7886KP & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & 67 & \(\pm 2.0\) & \(\mathrm{P}^{\circ}-28 \mathrm{~A}^{2}\) \\
AD7886BD & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 67 & \(\pm 2.0\) & \(\mathrm{P}-28 \mathrm{~A}^{2}\) \\
AD7886TD & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 65 & \(\pm 2.0\) & D-28 \\
\hline
\end{tabular}

NOTES
\({ }^{1}\) Contact your sales office for availability of AD7886BD, AD7886TD and 1 MHz version.
\({ }^{2}\) Analog Devices reserves the right to ship J-Leaded Ceramic Chip Carrier (JLCCC) in lieu of PLCC packages.
\({ }^{3}\) D \(=\) Ceramic DIP; P = Plastic Leaded Chip Carrier. For outline information see Package Information section.

\section*{PIN FUNCTION DESCRIPTION}


\section*{PIN CONFIGURATIONS}


\section*{TERMINOLOGY}

\section*{Unipolar Offset Error}

The ideal first code transition should occur when the analog input is 1 LSB above AGND. The deviation of the actual transition from that point is termed the offset error.

\section*{Bipolar Zero Error}

The ideal midscale transition (i.e., 011111111111 to 10000000 0000 for the \(\pm 5 \mathrm{~V}\) range should occur when the analog input is at zero volts. Bipolar zero error is the deviation of the actual transition from that point.

\section*{Gain Error}

In the unipolar mode, gain error is measured with respect to the first and last code transition points. The ideal difference between these points if FS-2 LSBs. For bipolar applications, the gain error is measured from the midscale transition to both the first and last code transitions. The ideal difference in this case is FS/2-1 LSB. The gain error is defined as the deviation between the ideal difference, given above, and the measured difference. For the bipolar case, there are two gain errors, the figure in the specification page represents the worst case. Ideal FS depends on the +5 REF input; for the 0 to 5 V input, ideal \(\mathrm{FS}=\)
+5 REF and for the 0 to 10 V and \(\pm 5 \mathrm{~V}\) ranges, ideal \(\mathrm{FS}=2 \times\) +5REF.

\section*{CONVERTER DETAILS}

The AD7886 is a triple-pass flash ADC which uses 15 comparators in a 4-bit flash technique to perform the 12 -bit conversion procedure. Each of the 4096 quantization levels is realized internally with a precision resistor DAC.

The fifteen comparators first compare the analog input voltage to the \(\mathrm{V}_{\mathrm{REF}} / 16\) voltages of the resistor array. This determines the four most significant bits and selects 1 out of 16 voltage segments. The comparators are then switched to 15 subvoltages on that segment to determine the next four bits and select 1 out of 256 voltage segments. A further switching of the comparators to
another 15 subvoltages produces the complete 12 -bit conversion result. The 12 bits of data are then stored internally in a threestate output latch.

\section*{REFERENCE INPUT}

The AD7886 operates from a -3.5 V reference which must be provided at the \(\mathrm{V}_{\text {REF }}\) input. Two on-chip resistors for use with an external amplifier can be used for deriving -3.5 V from standard 5 V references. Figure 2 shows an example with the AD586 which a is a high performance voltage reference which exhibits excellent stability performance, \(5 \mathrm{ppm} /{ }^{\circ} \mathrm{C}\) max. The external amplifier serves a second function of force/sensing the \(\mathrm{V}_{\mathrm{REF}}\) input. Force/sensing minimizes error contributions from


Figure 2. Typical Reference Circuitry
voltage or IR drops along the internal conductors. IR drops in the reference path cause a gain error, and typically the external amplifier reduces this error by 2 LSBs. In systems where a -3.5 V reference is available then it can be applied to the \(\mathrm{V}_{\mathrm{REF}}\) input directly causing a slight increase in gain error. A low op amp offset voltage is important as any offset voltage will add directly to the voltage that is being force/sensed. Suitable op amps for this application are precision op amps such as the AD705 or the AD707 which feature offset voltages of less than \(100 \mu \mathrm{~V}\).
Proper decoupling on the op amp output is important to suppress high speed transients during the conversion procedure. Note, connecting capacitors directly to op amp outputs can cause stability problems. However, the use of large capacitors, \(10 \mu \mathrm{~F}\) in Figure 2, limits the open-loop bandwidth preventing any closed-loop oscillations.

\section*{TRACK-AND-HOLD AMPLIFIER}

The analog input is sampled by an on-chip track-and-hold amplifier before being applied to the ADC. The 3 dB bandwidth of this amplifier is typically 20 MHz which is much greater than the Nyquist limit of the ADC, so it can be used for undersampling applications. The track-and-hold amplifier acquires the input signal to 12 -bit accuracy in less than 333 ns . The overall throughput time is equal to the conversion time plus the track/ hold amplifier acquisition time which is \(1.333 \mu \mathrm{~s}\) for the AD7886.
The operation of the track/hold amplifier is essentially transparent to the user. The track-to-hold transition occurs at the start of conversion on the falling edge of CONVST. The conversion procedure does not start until the rising edge of CONVST. The width of the CONVST pulse low time determines the track-tohold settling time. The track/hold reverts back to the track mode at the end of conversion when BUSY has returned high.


Figure 3. Analog Input Range Configurations

\section*{ANALOG INPUT RANGES}

The AD7886 has three user selectable analog input ranges: 0 to \(5 \mathrm{~V}, 0\) to 10 V and \(\pm 5 \mathrm{~V}\). Figure 3 shows how to configure the two analog inputs (VIN1 and VIN2) for these ranges.

\section*{UNIPOLAR OPERATION}

Figure 4 shows a typical unipolar circuit for the AD7886. The ideal input/output characteristic is shown in Figure 5. The designed code transitions occur on integer multiples of 1 LSB.
The output code is natural binary with \(1 \mathrm{LSB}=\mathrm{FS} / 4096\). FS is either +5 V or +10 V depending on how the analog inputs are configured.

*ADDITIONAL PINS OMITTED FOR CLARITY ** TO 5V RANGE: CONNECT VIN2 TO VIN1 0 TO 10V RANGE: CONNECT VIN2 TO AGND

Figure 4. Unipolar Operation


Figure 5. Ideal Input/Output Transfer Characteristic for Unipolar Operation

FEATURES
Fast 12-Bit ADC with \(1.3 \mu\) s Conversion Time
600 kSPS Throughput Rate (AD7892-3)
500 kSPS Throughput Rate (AD7892-1, AD7892-2)
Single Supply Operation
On-Chip Track/Hold Amplifier
Selection of Input Ranges:
\(\pm 10 \mathrm{~V}\) or \(\pm 5 \mathrm{~V}\) for AD7892-1
0 V to +2.5 V for AD7892-2
\(\pm 2.5 \mathrm{~V}\) for AD7892-3
High Speed Serial and Parallel Interface
Low Power, 60 mW typ
Overvoltage Protection on Analog Inputs (AD7892-1 and AD7892-3)

\section*{GENERAL DESCRIPTION}

The AD7892 is a high speed, low power, 12-bit A/D converter that operates from a single +5 V supply. The part contains a \(1.3 \mu \mathrm{~s}\) successive approximation ADC, an on-chip track/hold amplifier, an internal +2.5 V reference and on-chip versatile interface structures that allow both serial and parallel connection to a microprocessor. The part accepts an analog input range of \(\pm 10 \mathrm{~V}\) or \(\pm 5 \mathrm{~V}\) (AD7892-1), 0 V to +2.5 V (AD7892-2) and \(\pm 2.5 \mathrm{~V}\) (AD7892-3). Overvoltage protection on the analog inputs for the AD7892-1 and AD7892-3 allows the input voltage to go to \(\pm 17 \mathrm{~V}\) or \(\pm 7 \mathrm{~V}\) respectively without damaging the ports.
The AD7892 offers a choice of two data output formats: a single, parallel, 12-bit word or serial data. Fast bus access times and standard control inputs ensure easy parallel interface to microprocessors and digital signal processors. A high speed serial interface allows direct connection to the serial ports of microcontrollers and digital signal processors.
In addition to the traditional dc accuracy specifications such as linearity, full-scale and offset errors, the part is also specified for dynamic performance parameters including harmonic distortion and signal-to-noise ratio.

FUNCTIONAL BLOCK DIAGRAM


The AD7892 is fabricated in Analog Devices' Linear Compatible CMOS ( LC \(^{2}\) MOS) process, a mixed technology process that combines precision bipolar circuits with low-power CMOS logic. It is available in a 24 -pin, 0.3 " wide, plastic or hermetic DIP or in a 24 -pin SOIC.

\section*{PRODUCT HIGHLIGHTS}
1. The AD7892-3 features a conversion time of \(1.3 \mu \mathrm{~s}\) and a track/hold acquisition time of \(0.35 \mu \mathrm{~s}\). This allows a throughput rate for the part up to 600 ksps . The AD7892-1' and AD7892-2 operate with throughput rates of 500 ksps .
2. The AD7892 operates from a single +5 V supply and consumes 60 mW typ making it ideal for low power and portable applications.
3. The part offers a high speed, flexible interface arrangement with parallel and serial interfaces for easy connection to microprocessors, microcontrollers and digital signal processors.

\begin{tabular}{|c|c|c|c|c|c|}
\hline Parameter & A Versions \({ }^{1}\) & B Versions & S Version \({ }^{2}\) & Units & Test Conditions/Comments \\
\hline \begin{tabular}{l}
DYNAMIC PERFORMANCE \\
Signal to (Noise + Distortion) Ratio \({ }^{3}\) \\
Total Harmonic Distortion \({ }^{3}\) \\
Peak Harmonic or Spurious Noise \({ }^{3}\) \\
Intermodulation Distortion \({ }^{3}\) \\
2nd Order Terms \\
3rd Order Terms
\end{tabular} & \[
\begin{aligned}
& 70 \\
& -80 \\
& -81 \\
& -80 \\
& -80
\end{aligned}
\] & \[
\begin{aligned}
& 70 \\
& -80 \\
& -81 \\
& -80 \\
& -80
\end{aligned}
\] & \[
\begin{aligned}
& 70 \\
& -80 \\
& -81 \\
& -80 \\
& -80
\end{aligned}
\] & \begin{tabular}{l}
dB min \\
dB max \\
dB max \\
dB max \\
dB max
\end{tabular} & \(\mathrm{f}_{\mathrm{IN}}=100 \mathrm{kHz} . \mathrm{f}_{\text {SAMPLE }}=500 \mathrm{ksps}\) (AD7892-1 and AD7892-2) and 600 ksps (AD7892-3)
\[
\mathrm{fa}=49 \mathrm{kHz}, \mathrm{fb}=50 \mathrm{kHz}
\] \\
\hline \begin{tabular}{l}
DC ACCURACY \\
Resolution \\
Minimum Resolution for Which No \\
Missing Codes Are Guaranteed \\
Relative Accuracy \({ }^{3}\) \\
Differential Nonlinearity \({ }^{3}\) \\
Positive Full-Scale Error \({ }^{3}\) \\
AD7892-1 and AD7892-3 \\
Negative Full-Scale Error \({ }^{3}\) \\
Bipolar Zero Error \({ }^{3}\) \\
AD7892-2 Only \\
Unipolar Offset Error \({ }^{3}\)
\end{tabular} & \begin{tabular}{l}
12 \\
12 \\
\(\pm 4\) \\
\(\pm 4\) \\
\(\pm 3\)
\[
\pm 3
\]
\end{tabular} & \[
\begin{aligned}
& 12 \\
& 12 \\
& \pm 1 \\
& \pm 1 \\
& \pm 4 \\
& \pm 4 \\
& \pm 2 \\
& \pm 2 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 12 \\
& \\
& 12 \\
& \pm 1 \\
& \pm 1 \\
& \pm 4 \\
& \\
& \pm 4 \\
& \pm 3 \\
& \\
& \pm 3 \\
& \hline
\end{aligned}
\] &  & - \\
\hline \begin{tabular}{l}
ANALOG INPUT \\
AD7892-1 \\
Input Voltage Range \\
Input Voltage Range \\
Input Resistance \\
AD7892-2 \\
Input Voltage Range on \(\mathrm{V}_{\mathrm{IN} 1}\) \\
Input Current \\
Input Voltage Range on \(\mathrm{V}_{\mathrm{IN} 2}\) \\
AD7892-3 \\
Input Voltage Range on \(\mathrm{V}_{\mathrm{IN} 1}\) Input Resistance
\end{tabular} & \[
\begin{aligned}
& \pm 10 \\
& \pm 5 \\
& 8 \\
& 0 \text { to }+2.5 \\
& 50 \\
& \pm 50 \\
& \\
& \pm 2.5 \\
& 2
\end{aligned}
\] & \[
\begin{aligned}
& \pm 10 \\
& \pm 5 \\
& 8 \\
& \\
& 0 \text { to }+2.5 \\
& 50 \\
& \pm 50 \\
& \\
& \pm 2.5 \\
& 2
\end{aligned}
\] & \[
\begin{aligned}
& \pm 10 \\
& \pm 5 \\
& 8 \\
& \\
& 0 \text { to }+2.5 \\
& 50 \\
& \pm 50 \\
& \pm 2.5 \\
& 2
\end{aligned}
\] & \begin{tabular}{l}
Volts \\
Volts \\
\(k \Omega\) min \\
Volts \\
nA max \\
mV max \\
Volts \\
\(\mathrm{k} \Omega\) min
\end{tabular} & \begin{tabular}{l}
Input Applied to \(\mathrm{V}_{\mathrm{IN} 1}\) with \(\mathrm{V}_{\mathrm{IN} 2}\) Grounded Input Applied to \(\mathrm{V}_{\mathrm{IN} 1}\) and \(\mathrm{V}_{\mathrm{IN} 2}\) \\
Input Applied to \(\mathrm{V}_{\mathrm{IN} 1}\) with \(\mathrm{V}_{\mathrm{IN} 2}\) Grounded \\
Input Applied to \(\mathrm{V}_{\mathrm{IN} 1}\) and Referenced to \(\mathrm{V}_{\mathrm{IN} 2}\) \\
Input Applied to \(\mathrm{V}_{\text {IN } 1}\) with \(\mathrm{V}_{\mathrm{IN} 2}\) Unconnected
\end{tabular} \\
\hline \begin{tabular}{l}
REFERENCE OUTPUT/INPUT \\
REF IN Input Voltage Range \\
Input Impedance \\
Input Capacitance \({ }^{4}\) \\
REF OUT Output Voltage \\
REF OUT Error @ \(+25^{\circ} \mathrm{C}\) \\
\(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) \\
REF OUT Temperature Coefficient \\
REF OUT Output Impedance
\end{tabular} & \[
\begin{aligned}
& 2.375 / 2.625 \\
& 1.6 \\
& 10 \\
& 2.5 \\
& \pm 10 \\
& \pm 20 \\
& 25 \\
& 5.5
\end{aligned}
\] & \[
\begin{aligned}
& 2.375 / 2.625 \\
& 1.6 \\
& 10 \\
& 2.5 \\
& \pm 10 \\
& \pm 20 \\
& 25 \\
& 5.5
\end{aligned}
\] & \[
\begin{aligned}
& 2.375 / 2.625 \\
& 1.6 \\
& 10 \\
& 2.5 \\
& \pm 10 \\
& \pm 25 \\
& 25 \\
& 5.5 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
V min/V max \\
\(\mathrm{k} \Omega\) min \\
pF max \\
V nom \\
mV max \\
mV max \\
\(\mathrm{ppm} /{ }^{\circ} \mathrm{C}\) typ \\
\(\mathrm{k} \Omega\) nom
\end{tabular} & \begin{tabular}{l}
\[
2.5 \mathrm{~V} \pm 5 \%
\] \\
Resistor Connected to Internal Reference Node
\end{tabular} \\
\hline \begin{tabular}{l}
LOGIC INPUTS \\
Input High Voltage, \(\mathrm{V}_{\text {INH }}\) Input Low Voltage, \(\mathrm{V}_{\mathrm{INL}}\) Input Current, \(\mathrm{I}_{\mathrm{IN}}\) Input Capacitance, \(\mathrm{C}_{\mathrm{IN}}{ }^{4}\)
\end{tabular} & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 10 \\
& 10
\end{aligned}
\] & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 10 \\
& 10
\end{aligned}
\] & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 10 \\
& 10
\end{aligned}
\] & V min \(V\) max \(\mu \mathrm{A}\) max pF max & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \% \\
& \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \% \\
& \mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{DD}}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
LOGIC OUTPUTS \\
Output High Voltage, \(\mathrm{V}_{\mathrm{OH}}\) \\
Output Low Voltage, \(\mathrm{V}_{\mathrm{OL}}\) \\
DB11-DB0 \\
Floating-State Leakage Current \\
Floating-State Capacitance \({ }^{4}\) \\
Output Coding \\
AD7892-1 and AD7892-3 \\
AD7892-2
\end{tabular} & \[
\begin{aligned}
& 4.0 \\
& 0.4 \\
& \\
& \pm 10 \\
& 15
\end{aligned}
\]
\[
2 \mathrm{~s} \mathrm{C}
\]
Straight & \[
\begin{aligned}
& 4: 0 \\
& 0.4 \\
& \\
& \pm 10 \\
& 15 \\
& \text { mplement }
\end{aligned}
\]
Natural) Bina & \[
\begin{aligned}
& 4.0 \\
& 0.4 \\
& \\
& \pm 10 \\
& 15
\end{aligned}
\] & \begin{tabular}{l}
V min \\
V max \\
\(\mu \mathrm{A}\) max pF max
\end{tabular} & \[
\begin{aligned}
& I_{\text {SOURCE }}=200 \mu \mathrm{~A} \\
& \mathrm{I}_{\text {SINK }}=1.6 \mathrm{~mA}
\end{aligned}
\] \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|c|c|}
\hline Parameter & A Versions \({ }^{1}\) & B Versions & S Version \({ }^{2}\) & Units & Test Conditions/Comments \\
\hline CONVERSION RATE & & & & & \\
\hline Conversion Time & 1.3 & 1.3 & & \(\mu \mathrm{s}\) max & AD7892-3 \\
\hline Track/Hold Acquisition Time \({ }^{3}\) & 0.35 & 0.35 & & \(\mu \mathrm{s}\) max & AD7892-3 \\
\hline Conversion Time & 1.6 & 1.6 & 1.6 & \(\mu \mathrm{s} \max\) & AD7892-1 and AD7892-2 \\
\hline Track/Hold Acquisition Time \({ }^{3}\) & 0.4 & 0.4 & 0.4 & \(\mu \mathrm{s}\) max & AD7892-1 and AD7892-2 \\
\hline \multicolumn{6}{|l|}{POWER REQUIREMENTS} \\
\hline \(\mathrm{V}_{\mathrm{DD}}\) & +5 & +5 & +5 & \(V\) nom & \(\pm 5 \%\) for Specified Performance \\
\hline \(\mathrm{I}_{\mathrm{DD}}\) & & & & & \\
\hline Normal Operation & 18 & 18 & 18 & \(m A \max\) & \\
\hline Standby Mode \({ }^{5}\) & 250 & 250 & 250 & \(\mu \mathrm{A}\) typ & \\
\hline Power Dissipation & & & & & \\
\hline Normal Operation & 90 & 90 & 90 & \(\mathrm{mW}^{\text {max }}\) & \(\mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V}\). Typically 60 mW \\
\hline Standby Mode \({ }^{5}\) & 1.25 & 1.25 & 1.25 & mW typ & \\
\hline
\end{tabular}

NOTES
\({ }^{1}\) Temperature ranges are as follows: A, B Versions: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\); S Version: \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\).
\({ }^{2}\) S Version available on AD7892-1 and AD7892-2.
\({ }^{3}\) See Terminology.
\({ }^{4}\) Sample tested @ \(+25^{\circ} \mathrm{C}\) to ensure compliance.
\({ }^{5}\) This standby current is achieved with resistors to either DGND or \(V_{\text {DD }}\) on Pins \(8,9,16\) and 17 . A conversion should not be initiated on the part within \(30 \mu\) of exiting standby mode.
Specifications subject to change without notice.

\section*{ABSOLUTE MAXIMUM RATINGS*}
( \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) unless otherwise noted)
\(\mathrm{V}_{\mathrm{DD}}\) to AGND . . . . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to +7 V
\(\mathrm{V}_{\mathrm{DD}}\) to DGND . . . . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to +7 V
Analog Input Voltage to AGND


Reference Input Voltage to AGND . . . . -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
Digital Input Voltage to DGND . . . . . -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
Digital Output Voltage to DGND . . . . . -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
Operating Temperature Range
Commercial (A, B Versions). . . . . . . . . . . . . \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
Extended (S Version) . . . . . . . . . . . . . . . . . \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
Storage Temperature Range . . . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)

Junction Temperature . . . . . . . . . . . . . . . . . . . . . . . . \(+150^{\circ} \mathrm{C}\)
Plastic DIP Package, Power Dissipation . . . . . . . . . . 450 mW
\(\theta_{\mathrm{JA}}\) Thermal Impedance . . . . . . . . . . . . . . . . . . . . . . \(105^{\circ} \mathrm{C} / \mathrm{W}\)
Lead Temperature (Soldering, 10 sec ) . . . . . . . . . . \(+260^{\circ} \mathrm{C}\)
Cerdip Package, Power Dissipation . . . . . . . . . . . . . . 450 mW \(\theta_{\mathrm{JA}}\) Thermal Impedance . . . . . . . . . . . . . . . . . . . . . . . \(70^{\circ} \mathrm{C} / \mathrm{W}\)
Lead Temperature (Soldering, 10 sec ) . . . . . . . . . . . \(+300^{\circ} \mathrm{C}\)
SOIC Package, Power Dissipation. . . . . . . . . . . . . . . . 450 mW
\(\theta_{\mathrm{JA}}\) Thermal Impedance . . . . . . . . . . . . . . . . . . . . . . \(75^{\circ} \mathrm{C} / \mathrm{W}\)
Lead Temperature, Soldering
Vapor Phase ( 60 sec ) . . . . . . . . . . . . . . . . . . . . . . \(+215^{\circ} \mathrm{C}\)
Infrared (15 sec) . . . . . . . . . . . . . . . . . . . . . . . . . . . \(+220^{\circ} \mathrm{C}\)
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ORDERING GUIDE
\begin{tabular}{l|l|l|l|l|l}
\hline Model & Input Range & Sample Rate & Relative Accuracy & Temperature Range & Package Option \({ }^{\star}\) \\
\hline AD7892AN-1 & \(\pm 5 \mathrm{~V}\) or \(\pm 10 \mathrm{~V}\) & 500 ksps & & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\mathrm{N}-24\) \\
AD7892BN-1 & \(\pm 5 \mathrm{~V}\) or \(\pm 10 \mathrm{~V}\) & 500 ksps & \(\pm 1 \mathrm{LSB}\) & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\mathrm{N}-24\) \\
AD7892AR-1 & \(\pm 5 \mathrm{~V}\) or \(\pm 10 \mathrm{~V}\) & 500 ksps & & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\mathrm{R}-24\) \\
AD7892BR-1 & \(\pm 5 \mathrm{~V}\) or \(\pm 10 \mathrm{~V}\) & 500 ksps & \(\pm 1 \mathrm{LSB}\) & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\mathrm{R}-24\) \\
AD7892SQ-1 & \(\pm 5 \mathrm{~V}\) or \(\pm 10 \mathrm{~V}\) & 500 ksps & \(\pm 1 \mathrm{LSB}\) & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\mathrm{Q}-24\) \\
AD7892AN-2 & 0 V to +2.5 V & 500 ksps & & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\mathrm{N}-24\) \\
AD7892BN-2 & 0 V to +2.5 V & 500 ksps & \(\pm 1 \mathrm{LSB}\) & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\mathrm{N}-24\) \\
AD7892AR-2 & 0 V to +2.5 V & 500 ksps & & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\mathrm{R}-24\) \\
AD7892BR-2 & 0 V to +2.5 V & 500 ksps & \(\pm 1 \mathrm{LSB}\) & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\mathrm{R}-24\) \\
AD7892SQ-2 & 0 V to +2.5 V & 500 ksps & \(\pm 1 \mathrm{LSB}\) & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\mathrm{Q}-24\) \\
AD7892AN-3 & \(\pm 2.5 \mathrm{~V}\) & 600 ksps & & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\mathrm{N}-24\) \\
AD7892BN-3 & \(\pm 2.5 \mathrm{~V}\) & 600 ksps & \(\pm 1 \mathrm{LSB}\) & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\mathrm{N}-24\) \\
AD7892AR-3 & \(\pm 2.5 \mathrm{~V}\) & 600 ksps & & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\mathrm{R}-24\) \\
AD7892BR-3 & \(\pm 2.5 \mathrm{~V}\) & 600 ksps & \(\pm 1 \mathrm{LSB}\) & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\mathrm{R}-24\) \\
\hline
\end{tabular}
* \(\mathrm{N}=\) Plastic DIP; \(\mathrm{R}=\) SOIC; \(\mathbf{Q}=\) Cerdip. For outline information see Package Information section.

AD7892
TIMING CHARACTERISTICS \({ }^{1,2}\left(V_{D D}=+5 \mathrm{~V} \pm 5 \%, \operatorname{AGND}=\mathrm{DGND}=0 \mathrm{~V}, \operatorname{REF} \operatorname{IN}=+2.5 \mathrm{~V}\right)\)


\section*{NOTES}
\({ }^{1}\) Sample tested at \(+25^{\circ} \mathrm{C}\) to ensure compliance. All input signals are measured with \(\mathrm{tr}=\mathrm{tf}=1 \mathrm{~ns}(10 \%\) to \(90 \%\) of \(+5 \mathrm{~V})\) and timed from a voltage level of +1.6 V .
\({ }^{2}\) See Figures 2 and 3.
\({ }^{3}\) Measured with the load circuit of Figure 1 and defined as the time required for an output to cross 0.8 V or 2.4 V .
\({ }^{4}\) These times are derived from the measured time taken by the data outputs to change 0.5 V when loaded with the circuit of Figure 1 . The measured number is then extrapolated back to remove the effects of charging or discharging the 50 pF capacitor. This means that the times quoted in the timing characteristics are the true bus relinquish times of the part and as such are independent of external bus loading capacitances.
\({ }^{5}\) Assumes CMOS loads on data bits. With TTL loads, more current is drawn from the data lines and the \(\overline{\mathrm{RD}}\) to \(\overline{\mathrm{CONVST}}\) time needs to be extended to 300 ns min. Specifications subject to change without notice.


Figure 1. Load Circuit for Access Time and Bus Relinquish Time

\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD7892 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.
\begin{tabular}{|c|c|c|}
\hline \begin{tabular}{l}
Pin \\
No.
\end{tabular} & Mnemonic & Description \\
\hline 1 & \(\mathrm{V}_{\text {DD }}\) & Positive supply voltage, \(+5 \mathrm{~V} \pm 5 \%\). \\
\hline 2 & STANDBY & Standby Input. Logic Input. With this input at a logic high, the part is in its normal operating mode; with this input at a logic low, the part is placed in its standby or power-down mode, which reduces power consumption to 5 mW typical. \\
\hline 3 & \(\mathrm{V}_{\text {IN2 }}\) & \begin{tabular}{l}
Analog Input 2. For the AD7892-1, this input either connects to AGND or to \(\mathrm{V}_{\mathrm{IN} 1}\) to determine the analog input voltage range. With \(\mathrm{V}_{\mathrm{IN} 2}\) connected to AGND on the AD7892-1, the analog input range at the \(\mathrm{V}_{\mathrm{IN} 1}\) input is \(\pm 10 \mathrm{~V}\). With \(\mathrm{V}_{\mathrm{IN} 2}\) connected to \(\mathrm{V}_{\mathrm{IN} 1}\) on the AD7892-1, the analog input range to the part is \(\pm 5 \mathrm{~V}\). \\
For the AD7892-2, the voltage range at the \(\mathrm{V}_{\mathrm{IN} 1}\) input is referenced to the voltage applied to the \(\mathrm{V}_{\mathrm{IN} 2}\) input. The allowable span for the \(\mathrm{V}_{\mathrm{IN} 2}\) voltage is \(\pm 50 \mathrm{mV}\). With \(\mathrm{V}_{\mathrm{IN} 2}\) at AGND on the AD7892-2, the analog input voltage range at the \(\mathrm{V}_{\text {IN } 1}\) input is 0 to +2.5 V . \\
For the AD7892-3, this input should be connected to AGND.
\end{tabular} \\
\hline 4 & \(\mathrm{V}_{\text {IN } 1}\) & Analog Input 1. The analog input voltage to be converted by the AD7892 is applied to this input. For the AD7892-1, the input voltage range is either \(\pm 5 \mathrm{~V}\) or \(\pm 10 \mathrm{~V}\) depending on where the \(\mathrm{V}_{\text {IN2 }}\) input is connected. For the AD7892-2, the voltage range on the \(\mathrm{V}_{\text {IN } 1}\) input is 0 V to +2.5 V with respect to the voltage appearing at the \(\mathrm{V}_{\mathrm{IN} 2}\) input. For the \(\mathrm{AD} 7892-3\), the voltage range on the \(\mathrm{V}_{\text {IN1 }}\) input is \(\pm 2.5 \mathrm{~V}\). \\
\hline 5 & REF OUT/REF IN & Voltage Reference Output/Input. The part can be used with either its own internal reference or with an external reference source. The on-chip +2.5 V reference is provided at this pin. When using this internal reference as the reference source for the part, REF OUT should be decoupled to AGND with a \(0.1 \mu \mathrm{~F}\) disc ceramic capacitor. The output impedance of this reference source is typically \(5.5 \mathrm{k} \Omega\). When using an external reference source as the reference voltage for the part, the reference source should be connected to this pin. This overdrives the internal reference and provides the reference source for the part. The REF IN input is buffered on-chip but must be able to sink or source current through the resistor to the output of the on-chip reference. The nominal reference voltage for correct operation of the AD7892 is +2.5 V . \\
\hline 6 & AGND & Analog Ground. Ground reference for track/hold, comparator and DAC. \\
\hline 7 & MODE & Mode. Control input which determines the interface mode for the AD7892. With this pin at a logic low, the device is in its serial interface mode; with this pin at a logic high, the device is in its parallel interface mode. \\
\hline 8 & DB11/LOW & Data Bit \(11 /\) Test Pin. When the device is in its parallel mode, this pin is Data Bit 11 (MSB), a three-state TTL-compatible output. When the device is in its serial mode, this is used as a test pin which must be tied to a logic low for correct operation of the AD7892 \\
\hline 9 & DB10/LOW & Data Bit \(10 /\) Test Pin. When the device is in its parallel mode, this pin is Data Bit 10, a threestate TTL-compatible output. When the device is in its serial mode, this is used as a test pin which must be tied to a logic low for correct operation of the AD7892. \\
\hline 10 & DB9 & Data Bit 9. Three-state TTL-compatible output. This output should be left unconnected when the device is in its serial mode. \\
\hline 11 & DB8 & Data Bit 8 . Three-state TTL-compatible output. This output should be left unconnected when the device is in its serial mode. \\
\hline 12 & DB7 & Data Bit 7. Three-state TTL-compatible output. This output should be left unconnected when the device is in its serial mode. \\
\hline 13 & DB6 & Data Bit 6. Three-state TTL-compatible output. This output should be left unconnected when the device is in its serial mode. \\
\hline 14 & DGND & Digital Ground. Ground reference for digital circuitry. \\
\hline 15 & DB5/SDATA & Data Bit 5/Serial Data. When the device is in its parallel mode, this pin is Data Bit 5, a three-state TTL-compatible output. When the device is in its serial mode, this becomes the serial data output line. Sixteen bits of serial data are provided with four leading zeros preceding the 12 -bits of valid data. Serial data is valid on the falling edge of SCLK for sixteen edges after \(\overline{\mathrm{RFS}}\) goes low. Output coding is 2s complement for AD7892-1 and AD7892-3 and straight (natural) binary for AD7892-2. \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|}
\hline \begin{tabular}{l}
Pin \\
No.
\end{tabular} & Mnemonic & Description \\
\hline 16 & DB4/SCLK & Data Bit 4/Serial Clock. When the device is in its parallel mode, this pin is Data Bit 4, a three-state TTL-compatible output. When the device is in its serial mode, this becomes the serial clock pin, SCLK. SCLK is an input and an external serial clock must be provided at this pin to obtain serial data from the AD7892. Serial data is clocked out from the output shift register on the rising edges of SCLK after \(\overline{\mathrm{RFS}}\) goes low. \\
\hline 17 & DB3/ \(\overline{\mathrm{RFS}}\) & Data Bit 3/Receive Frame Synchronization. When the device is in its parallel mode, this pin is Data Bit 3, a three-state TTL-compatible output. When the device is in its serial mode, this becomes the receive frame synchronization input with \(\overline{\mathrm{RFS}}\) provided externally to obtain serial data from the AD7892. \\
\hline 18 & DB2 & Data Bit 2. Three-state TTL-compatible output. This output should be left unconnected when the device is in its serial mode. \\
\hline 19 & DB1 & Data Bit 1. Three-state TTL-compatible output. This output should be left unconnected when the device is in its serial mode. \\
\hline 20 & DB0 & Data Bit 0 (LSB). Three-state TTL-compatible output. Output coding is 2 s complement for AD7892-1 and AD7892-3 and straight (natural) binary for AD7892-2. This output should be left unconnected when the device is in its serial mode. \\
\hline 21 & \(\overline{\mathrm{RD}}\) & Read. Active low logic input which is used in conjunction with \(\overline{\mathrm{CS}}\) low to enable the data outputs. \\
\hline 22 & \(\overline{\mathrm{CS}}\) & Chip Select. Active low logic input which is used in conjunction with \(\overline{\mathrm{RD}}\) to enable he data outputs. \\
\hline 23 & \(\overline{\overline{\text { EOC }}}\) & End-of-Conversion. Active low logic output indicating converter status. The end of conversion is signified by a low-going pulse on this line. The duration of this EOC pulse is nominally 100 ns . \\
\hline 24 & CONVST & Convert Start. Logic Input. A low to high transition on this input puts the track/hold into its hold mode and starts conversion. \\
\hline
\end{tabular}

\section*{PIN CONFIGURATION}

DIP and SOIC


\section*{CIRCUIT DESCRIPTION}

The AD7892 is a fast, 12 -bit single supply A/D converter. It provides the user with signal scaling, track/hold, reference, \(\mathrm{A} / \mathrm{D}\) converter and versatile interface logic functions on a single chip. The signal scaling on the AD7892-1 allows the part to handle either \(\pm 5 \mathrm{~V}\) or \(\pm 10 \mathrm{~V}\) input signals while operating from a single +5 V supply. The AD7892-2 handles a 0 to +2.5 V analog input range, while signal scaling on the AD7892-3 allows it to handle \(\pm 2.5 \mathrm{~V}\) input signals when operating from a single supply. The part requires a +2.5 V reference which can be provided from the part's own internal reference or from an external reference source.
Conversion is initiated on the AD7892 by pulsing the \(\overline{\text { CONVST }}\) input. On the rising edge of CONVST, the track/hold goes from track mode to hold mode and the conversion sequence is started. At the end of conversion (falling edge of EOC), the track/hold returns to tracking mode and the acquisition time begins. Conversion time for the part is \(1.3 \mu \mathrm{~s}\) (AD7892-3) and the track/hold acquisition time is 350 ns (AD7892-3). This allows the AD7892-3 to operate at throughput rates up to 600 ksps . The AD7892-1 and AD7892-2 are specified with a \(1.6 \mu \mathrm{~s}\) conversion and 400 ns acquisition time allowing a throughput rate of 500 ksps .

\section*{Track/Hold Section}

The track/hold amplifier on the AD7892 allows the ADC to accurately convert an input sine wave of full-scale amplitude to 12-bit accuracy. The input bandwidth of the track/hold is greater than the Nyquist rate of the ADC even when the ADC is operated at its maximum throughput rate of 600 kHz (i.e., the track/hold can handle input frequencies in excess of 300 kHz ).
The track/hold amplifier acquires an input signal to 12-bit accuracy in less than 350 ns . The operation of the track/hold is essentially transparent to the user. The track/hold amplifier goes from its tracking mode to its hold mode on the rising edge of CONVST. The aperture time for the track/hold (i.e., the delay time between the external CONVST signal and the track/hold actually going into hold) is typically 15 ns . At the end of conversion, the part returns to its tracking mode. The acquisition time of the track/hold amplifier begins at this point.

\section*{Reference Section}

The AD7892 contains a single reference pin, labelled REF OUT/REF IN, which either provides access to the part's own +2.5 V reference or to which an external +2.5 V reference
can be connected to provide the reference source for the part. The part is specified with a +2.5 V reference voltage. Errors in the reference source will result in gain errors in the AD7892's transfer function and will add to the specified full-scale errors on the part. On the AD7892-1 and AD7892-3, it will also result in an offset error injected in the attenuator stage.
The AD7892 contains an on-chip +2.5 V reference. To use this reference as the reference source for the AD7892, simply connect a \(0.1 \mu \mathrm{~F}\) disc ceramic capacitor from the REF OUT/ REF IN pin to AGND. The voltage that appears at this pin is internally buffered before being applied to the ADC. If this reference is required for use external to the AD7892, it should be buffered as the part has a FET switch in series with the reference output resulting in a source impedance for this output of \(5.5 \mathrm{k} \Omega\) nominal. The tolerance on the internal reference is \(\pm 10 \mathrm{mV}\) at \(25^{\circ} \mathrm{C}\) with a typical temperature coefficient of \(25 \mathrm{ppm} /{ }^{\circ} \mathrm{C}\) and a maximum error over temperature of \(\pm 25 \mathrm{mV}\).
If the application requires a reference with a tighter tolerance or the AD7892 needs to be used with a system reference, then the user has the option of connecting an external reference to this REF OUT/REF IN pin. The external reference will effectively overdrive the internal reference and thus provide the reference source for the ADC. The reference input is buffered before being applied to the ADC with the maximum input current is \(\pm 100 \mu \mathrm{~A}\). Suitable reference sources for the AD7892 include the AD680, AD780 and REF43 precision +2.5 V references.

\section*{INTERFACING}

The part provides two interface options, a 12-bit parallel interface and a three-wire serial interface. The required interface mode is selected via the MODE pin. The two interface modes are discussed in the following sections.

\section*{Parallel Interface Mode}

The parallel interface mode is selected by tying the MODE input to a logic high. Figure 2 shows a timing diagram illustrating the operational sequence of the AD7892. The on-chip track/ hold goes into hold mode, and conversion is initiated on the rising edge of the CONVST signal. When conversion is complete, the end of conversion line ( \(\overline{\mathrm{EOC}})\) pulses low to indicate that new data is available in the AD7892's output register. This \(\overline{\mathrm{EOC}}\) line can be used to drive an edge-triggered interrupt of a microprocessor. The read operation should be completed 200 ns prior to the next rising edge of \(\overline{\text { CONVST }} . \overline{\mathrm{CS}}\) and \(\overline{\mathrm{RD}}\)


Figure 2. Parallel Mode Timing Diagram

\section*{AD7892}
going low accesses the 12 -bit conversion result. In systems where the part is interfaced to a gate array or ASIC, this \(\overline{\mathrm{EOC}}\) pulse can be applied to the \(\overline{\mathrm{CS}}\) and \(\overline{\mathrm{RD}}\) inputs to latch data out of the AD7892 and into the gate array or ASIC. This eliminates the logic required in the gate array or ASIC to recognize the end of conversion and generate the read signal for the AD7892. To obtain optimum performance from the AD7892, it is not recommended to tie \(\overline{\mathrm{CS}}\) and \(\overline{\mathrm{RD}}\) permanently low as this keeps the three-state active during conversion.

\section*{Serial Interface Mode}

The AD7892 is configured for serial mode interfacing by tying the MODE input low. It provides for a three-wire, serial link between the AD7892 and industry-standard microprocessors, microcontrollers and digital signal processors. SCLK and RFS of the AD7892 are inputs, and the AD7892's serial interface is designed for direct interface to systems that provide a serial clock input that is synchronized to the serial data output including microcontrollers such as the \(80 \mathrm{C} 51,87 \mathrm{C} 51,68 \mathrm{HC} 11\) and 68 HC 05 and most digital signal processors.
Figure 3 shows the timing diagram for reading from the AD7892 in the serial interface mode. \(\overline{\mathrm{RFS}}\) goes low to access data from the AD7892. The serial clock input does not have to be continuous. The serial data can be accessed in a number of bytes. However, \(\overline{\mathrm{RFS}}\) must remain low for the duration of the data transfer operation. Sixteen bits of data are transmitted
with four leading zeros followed by the 12-bit conversion result starting with the MSB. Serial data is clocked out of the device on the rising edge of SCLK. Old data is guaranteed to be valid for 5 ns after this edge. This is useful for high speed serial clocks where the access time of the part would not allow sufficient setup time for the data to be accepted on the falling edge of the clock. In this case, care must be taken that \(\overline{\mathrm{RFS}}\) does not go just prior to a rising edge of SCLK. For slower serial clocks data is valid on the falling edge of SCLK. At the end of the read operation, the SDATA line is three-stated by a rising edge on either the SCLK of RFS inputs, whichever occurs first. Serial data cannot be read during conversion to avoid feedthrough problems from the serial clock to the conversion process. For optimum performance, a serial read should also be avoided within 400 ns of the rising edge of CONVST to avoid feedthrough into the track/hold during its acquisition time. The serial read should, therefore, occur between the end of conversion (EOC falling edge) and 400 ns prior to the next rising edge of CONVST. This limits the maximum achievable throughput rate in serial mode (assuming 20 MHz serial clock) to 400 ksps for the AD7892-3 and 357 ksps for the AD7892-1 and AD7892-2.


Figure 3. Serial Mode Timing Diagram

FEATURES
Fast 12-Bit ADC with \(6 \mu\) s Conversion Time
8-Pin Mini-DIP and SOIC
Single Supply Operation
High Speed, Easy-to-Use, Serial Interface
On-Chip Track/Hold Amplifier
Selection of Input Ranges
\(\pm 10\) V for AD7893-10
0 V to +2.5 V for AD7893-2
Low Power: \(\mathbf{2 5} \mathbf{m W}\) typ

FUNCTIONAL BLOCK DIAGRAM


\section*{PRODUCT HIGHLIGHTS}
1. Fast, 12-Bit ADC in 8-Pin Package

The AD7893 contains a \(6 \mu\) ADC, a track/hold amplifier, control logic and a high speed serial interface, all in an 8 -pin package. This offers considerable space saving over alternative solutions.
2. Low Power, Single Supply Operation

The AD7893 operates from a single +5 V supply and consumes only 25 mW . This low power, single supply operation makes it ideal for battery-powered or portable applications.
3. High Speed Serial Interface

The part provides high speed serial data and serial clock lines allowing for an easy, two-wire serial interface arrangement.

\begin{tabular}{|c|c|c|c|c|c|}
\hline Parameter & \[
\begin{aligned}
& \mathrm{A} \\
& \text { Versions }^{1}
\end{aligned}
\] & \begin{tabular}{l}
B \\
Versions
\end{tabular} & \begin{tabular}{l}
\[
\mathbf{S}
\] \\
Version
\end{tabular} & Units & Test Conditions/Comments \\
\hline \begin{tabular}{l}
DYNAMIC PERFORMANCE \\
Signal to (Noise + Distortion) Ratio \({ }^{2}\)
\[
@+25^{\circ} \mathrm{C}
\]
\[
\mathrm{T}_{\text {MIN }} \text { to } \mathrm{T}_{\text {MAX }}
\] \\
Total Harmonic Distortion (THD) \({ }^{2}\) \\
Peak Harmonic or Spurious Noise \({ }^{2}\) Intermodulation Distortion (IMD) \({ }^{2}\) 2nd Order Terms 3rd Order Terms
\end{tabular} & 70
-80
-80
-80
-80 & \[
\begin{aligned}
& 70 \\
& 70 \\
& -80 \\
& -80 \\
& -80 \\
& -80
\end{aligned}
\] & \[
\begin{aligned}
& 70 \\
& -80 \\
& -80 \\
& -80 \\
& -80
\end{aligned}
\] & dB min dB min dB max dB max dB max dB max & \[
\begin{aligned}
& \mathrm{f}_{\mathrm{IN}}=10 \mathrm{kHz} \text { Sine Wave, } \mathrm{f}_{\text {SAMPLE }}=117 \mathrm{kHz} \\
& \mathrm{f}_{\mathrm{IN}}=10 \mathrm{kHz} \text { Sine Wave, } \mathrm{f}_{\text {SAMPLE }}=117 \mathrm{kHz} \\
& \mathrm{f}_{\mathrm{IN}}=10 \mathrm{kHz} \text { Sine Wave, } \mathrm{f}_{\text {SAMPLE }}=117 \mathrm{kHz} \\
& \mathrm{fa}=9 \mathrm{kHz}, \mathrm{fb}=9.5 \mathrm{kHz}, \mathrm{f}_{\text {SAMPLE }}=117 \mathrm{kHz}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
DC ACCURACY \\
Resolution Minimum Resolution for which No Missing Codes are Guaranteed Relative Accuracy \({ }^{2}\) Differential Nonlinearity \({ }^{2}\) Positive Full-Scale Error \({ }^{2}\) AD7893-2 Only \\
Unipolar Offset Error AD7893-10 Only Negative Full-Scale Error \({ }^{2}\) Bipolar Zero Error
\end{tabular} & \begin{tabular}{l}
12 \\
12 \\
\(\pm 1\) \\
\(\pm 1\) \\
\(\pm 3\) \\
\(\pm 4\) \\
\(\pm 3\) \\
\(\pm 4\) \\
\hline
\end{tabular} & \[
\begin{aligned}
& 12 \\
& 12 \\
& \pm 1 / 2 \\
& \pm 1 \\
& \pm 1.5 \\
& \pm 3 \\
& \\
& \pm 1.5 \\
& \pm 2
\end{aligned}
\] & \[
\begin{aligned}
& 12 \\
& 12 \\
& \pm 1 \\
& \pm 1 \\
& \pm 3 \\
& \pm 4 \\
& \\
& \pm 3 \\
& \pm 4
\end{aligned}
\] & \begin{tabular}{l}
Bits \\
Bits \\
LSB max \\
LSB max \\
LSB max \\
LSB max \\
LSB max \\
LSB max
\end{tabular} & \\
\hline \begin{tabular}{l}
ANALOG INPUT \\
AD7893-10 \\
Input Voltage Range \\
Input Resistance \\
AD7893-5 \\
Input Voltage Range \\
Input Resistance \\
AD7893-2 \\
Input Voltage Range Input Current
\end{tabular} & \[
\left\lvert\, \begin{aligned}
& \pm 10 \\
& 16 \\
& 0 \text { to }+5 \\
& 9 \\
& 0 \text { to }+2.5 \\
& 500
\end{aligned}\right.
\] & \[
\begin{aligned}
& \pm 10 \\
& 16 \\
& 0 \text { to }+5 \\
& 9 \\
& 0 \text { to }+2.5 \\
& 500
\end{aligned}
\] & \[
\begin{aligned}
& \pm 10 \\
& 16 \\
& 0 \text { to }+5 \\
& 9 \\
& 0 \text { to }+2.5 \\
& 500
\end{aligned}
\] & \begin{tabular}{l}
Volts \(\mathrm{k} \Omega\) min \\
Volts \(\mathrm{k} \Omega\) min \\
Volts nA max
\end{tabular} & , \\
\hline \begin{tabular}{l}
REFERENCE INPUT \\
REF IN Input Voltage Range Input Current Input Capacitance \({ }^{3}\)
\end{tabular} & \[
\begin{aligned}
& 2.375 / 2.625 \\
& 2 \\
& 10
\end{aligned}
\] & \[
\begin{aligned}
& 2.375 / 2.625 \\
& 2 \\
& 10
\end{aligned}
\] & \[
\begin{aligned}
& 2.375 / 2.625 \\
& 10 \\
& 10
\end{aligned}
\] & \(V \min / V \max\) \(\mu \mathrm{A}\) max pF max & \(2.5 \mathrm{~V} \pm 5 \%\) \\
\hline \begin{tabular}{l}
LOGIC INPUTS \\
Input High Voltage, \(\mathrm{V}_{\text {INH }}\) Input Low Voltage, \(\mathrm{V}_{\mathrm{INL}}\) Input Current, \(\mathrm{I}_{\text {IN }}\) Input Capacitance, \(\mathrm{C}_{\mathrm{IN}}{ }^{3}\)
\end{tabular} & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 10 \\
& 10
\end{aligned}
\] & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 10 \\
& 10
\end{aligned}
\] & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 10 \\
& 10
\end{aligned}
\] & \begin{tabular}{l}
V min \\
V max \\
\(\mu \mathrm{A}\) max \\
pF max
\end{tabular} & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \% \\
& \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \% \\
& \mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{DD}}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
LOGIC OUTPUTS \\
Output High Voltage, \(\mathrm{V}_{\mathrm{OH}}\) Output Low Voltage, \(\mathrm{V}_{\mathrm{OL}}\) Output Coding AD7893-10 AD7893-2
\end{tabular} & \begin{tabular}{l}
\[
\begin{aligned}
& 4.0 \\
& 0.4
\end{aligned}
\] \\
Stra
\end{tabular} & \begin{tabular}{l}
4.0 \\
0.4 \\
s Compleme \\
ht (Natural)
\end{tabular} & \begin{tabular}{l}
4.0 \\
0.4 \\
Binary
\end{tabular} & \begin{tabular}{l}
\(V \min\) \\
V max
\end{tabular} & \[
\begin{aligned}
& I_{\text {SOURCE }}=200 \mu \mathrm{~A} \\
& \mathrm{I}_{\text {SINK }}=1.6 \mathrm{~mA}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
CONVERSION RATE \\
Conversion Time Track/Hold Acquisition Time \({ }^{2}\)
\end{tabular} & \[
\begin{array}{|l|}
\hline 6 \\
1.5
\end{array}
\] & \[
\begin{aligned}
& 6 \\
& 1.5
\end{aligned}
\] & \[
\begin{aligned}
& 6 \\
& 1.5
\end{aligned}
\] & \(\mu \mathrm{s}\) max \(\mu s\) max & \\
\hline \begin{tabular}{l}
POWER REQUIREMENTS \\
\(V_{D D}\) \\
\(\mathrm{I}_{\mathrm{DD}}\) \\
Power Dissipation
\end{tabular} & \[
\begin{aligned}
& +5 \\
& 9 \\
& 45
\end{aligned}
\] & \[
\begin{aligned}
& +5 \\
& 9 \\
& 45
\end{aligned}
\] & \[
\begin{aligned}
& +5 \\
& 9 \\
& 45
\end{aligned}
\] & V nom mA max mW max & \begin{tabular}{l}
\(\pm 5 \%\) for Specified Performance \\
Typically 25 mW
\end{tabular} \\
\hline
\end{tabular}

\footnotetext{
NOTES
\({ }^{1}\) Temperature Ranges are as follows: A, B Versions: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\); S Version: \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\).
\({ }^{2}\) See Terminology.
\({ }^{3}\) Sample tested @ \(+25^{\circ} \mathrm{C}\) to ensure compliance.
Specifications subject to change without notice.
}

TIMING CHARACTERISTICS \({ }^{1,2}{ }_{\left(v_{00}=+5 v, ~ A G N D\right.}=\) OGVD \(=0 \mathrm{~V}\), REF IW \(\left.=+2.5 \mathrm{v}\right)\)
\begin{tabular}{l|l|l|l|l}
\hline Parameter & \begin{tabular}{l} 
A, B \\
Versions
\end{tabular} & \begin{tabular}{l} 
S \\
Version
\end{tabular} & Units & Test Conditions/Comments \\
\hline \(\mathrm{t}_{1}\) & 50 & 50 & \(\mathrm{~ns} \min\) & CONVST Pulse Width \\
\(\mathrm{t}_{2}\) & 60 & 70 & ns min & SCLK High Pulse Width \\
\(\mathrm{t}_{3}\) & 30 & 40 & ns min & SCLK Low Pulse Width \\
\(\mathrm{t}_{4}{ }^{3}\) & 50 & 60 & ns max & SCLK Rising Edge to Data Valid Delay \\
\(\mathrm{t}_{5}{ }^{4}\) & 10 & 10 & ns min & Bus Relinquish Time after Falling Edge of SCLK \\
& 100 & 100 & ns max & \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Sample tested at \(+25^{\circ} \mathrm{C}\) to ensure compliance. All input signals are measured with \(\mathrm{tr}=\mathrm{tf}=1 \mathrm{~ns}(10 \%\) to \(90 \%\) of \(+5 \mathrm{~V})\) and timed from a voltage level of +1.6 V .
\({ }^{2}\) See Figure 5.
\({ }^{3}\) Measured with the load circuit of Figure 1 and defined as the time required for an output to cross 0.8 V or 2.4 V .
\({ }^{4}\) Derived from the measured time taken by the data outputs to change 0.5 V when loaded with the circuit of Figure 1 . The measured number is then extrapolated back to remove the effects of charging or discharging the 50 pF capacitor. This means that the time, \(\mathrm{t}_{5}\), quoted in the timing characteristics is the true bus relinquish time of the part and as such is independent of external bus loading capacitances.

\section*{ABSOLUTE MAXIMUM RATINGS*}
\begin{tabular}{|c|c|}
\hline \multicolumn{2}{|l|}{( \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) unless otherwise noted)} \\
\hline \(\mathrm{V}_{\mathrm{DD}}\) to AGND & V to +7 V \\
\hline \multicolumn{2}{|l|}{\(\mathrm{V}_{\text {DD }}\) to DGND} \\
\hline \multicolumn{2}{|l|}{Analog Input Voltage to AGND} \\
\hline \multicolumn{2}{|l|}{AD7893-10, AD7893-5} \\
\hline \multicolumn{2}{|l|}{AD7893-2} \\
\hline \multicolumn{2}{|l|}{Reference Input Voltage to AGND . . -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)} \\
\hline \multicolumn{2}{|l|}{Digital Input Voltage to DGND . . . -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)} \\
\hline \multicolumn{2}{|l|}{Digital Output Voltage to DGND . . -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)} \\
\hline \multicolumn{2}{|l|}{Operating Temperature Range} \\
\hline \multicolumn{2}{|l|}{Commercial (A, B Versions)} \\
\hline \multicolumn{2}{|l|}{Extended (S Version)} \\
\hline \multicolumn{2}{|l|}{\multirow[t]{2}{*}{Storage Temperature Range . . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\) Junction Temperature . . . . . . . . . . . . . . . . . . . . . . \(+150^{\circ} \mathrm{C}\)}} \\
\hline & \\
\hline \multicolumn{2}{|l|}{Plastic DIP Package, Power Dissipation . . . . . . . . . . 450 mW} \\
\hline \multicolumn{2}{|l|}{\(\theta_{\text {JA }}\) Thermal Impedance} \\
\hline \multicolumn{2}{|l|}{Lead Temperature, (Soldering, 10 sec ) . . . . . . . . \(+260^{\circ} \mathrm{C}\)} \\
\hline \multicolumn{2}{|l|}{Cerdip Package, Power Dissipation . . . . . . . . . . . . 450 mW} \\
\hline \multicolumn{2}{|l|}{\(\theta_{\text {JA }}\) Thermal Impedance . . . . . . . . . . . . . . . . . \(125^{\circ} \mathrm{C} / \mathrm{W}\)} \\
\hline \multicolumn{2}{|l|}{Lead Temperature, (Soldering, 10 secs) . . . . . . . . \(+300^{\circ} \mathrm{C}\)} \\
\hline \multicolumn{2}{|l|}{SOIC Package, Power Dissipation . . . . . . . . . . . . . 450 mW} \\
\hline \multicolumn{2}{|l|}{\(\theta_{\mathrm{JA}}\) Thermal Impedance . . . . . . . . . . . . . . . . . 170 \({ }^{\circ} \mathrm{C} / \mathrm{W}\)} \\
\hline \multicolumn{2}{|l|}{Lead Temperature, Soldering} \\
\hline \multicolumn{2}{|l|}{Vapor Phase (60 sec)} \\
\hline \multicolumn{2}{|l|}{Infrared (15 sec)} \\
\hline
\end{tabular}
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD7893 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


\section*{PIN FUNCTION DESCRIPTION}
\begin{tabular}{|c|c|c|}
\hline \begin{tabular}{l}
Pin \\
No.
\end{tabular} & \begin{tabular}{l}
Pin \\
Mnemonic
\end{tabular} & Description \\
\hline 1 & REF IN & Voltage Reference Input. An external reference source should be connected to this pin to provide the reference voltage for the AD7893's conversion process. The REF IN input is buffered on-chip. The nominal reference voltage for correct operation of the AD7893 is +2.5 V . \\
\hline 2 & \(\mathrm{V}_{\text {IN }}\) & Analog Input Channel. The analog input range is \(\pm 10 \mathrm{~V}\) (AD7893-10), 0 to +5 V (AD7893-5) and 0 to +2.5 V (AD7893-2). \\
\hline 3 & AGND & Analog Ground. Ground reference for track/hold, comparator and DAC. \\
\hline 4 & SCLK & Serial Clock Input. An external serial clock is applied to this input to obtain serial data from the AD7893. A new serial data bit is clocked out on the rising edge of this serial clock and data is valid on the falling edge. The serial clock input should be taken low at the end of the serial data transmission. \\
\hline 5 & SDATA & Serial Data Output. Serial data from the AD7893 is provided at this output. The serial data is clocked out by the rising edge of SCLK and is valid on the falling edge of SCLK. Sixteen bits of serial data are provided with four leading zeros followed by the 12-bits of conversion data. On the sixteenth falling edge of SCLK, the SDATA line is disabled (three-stated). Output data coding is twos complement for the AD7893-10 and straight binary for the AD7893-2 and AD7893-5. \\
\hline 6 & DGND & Digital Ground. Ground reference for digital circuitry. \\
\hline 7 & CONVST & Convert Start. Edge-triggered logic input. On the falling edge of this input, the serial clock counter is reset to zero. On the rising edge of this input, the track/hold goes into its hold mode and conversion is initiated. \\
\hline 8 & \(\mathrm{V}_{\mathrm{DD}}\) & Positive supply voltage, \(+5 \mathrm{~V} \pm 5 \%\). \\
\hline
\end{tabular}

\section*{PIN CONFIGURATION}

\section*{DIP and SOIC}


ORDERING GUIDE
\begin{tabular}{l|l|l|l|l}
\hline Model & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Linearity \\
Error (LSB)
\end{tabular} & \begin{tabular}{l} 
SNR \\
(dB)
\end{tabular} & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD7893AN-2 & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & 70 dB & \(\mathrm{~N}-8\) \\
AD7893BN-2 & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & 72 dB & \(\mathrm{~N}-8\) \\
AD7893AR-2 & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & 70 dB & SO-8 \\
AD7893BR-2 & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & 72 dB & SO-8 \\
AD7893SQ-2 & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & 70 dB & \(\mathrm{Q}-8\) \\
AD7893AN-5 & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1\) LSB & 70 dB & \(\mathrm{~N}-8\) \\
AD7893BN-5 & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & 72 dB & \(\mathrm{~N}-8\) \\
AD7893AR-5 & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & 70 dB & SO-8 \\
AD7893BR-5 & \(-40^{\circ}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & 72 dB & SO-8 \\
AD7893SQ-5 & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & 70 dB & \(\mathrm{Q}-8\) \\
AD7893AN-10 & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & 70 dB & \(\mathrm{~N}-8\) \\
AD7893BN-10 & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & 72 dB & \(\mathrm{~N}-8\) \\
AD7893AR-10 & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & 70 dB & SO-8 \\
AD7893BR-10 & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & 72 dB & SO-8 \\
AD7893SQ-10 & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & 70 dB & \(\mathrm{Q}-8\) \\
\hline
\end{tabular}
\(\star \mathrm{N}=\) Plastic DIP, \(\mathrm{Q}=\) Cerdip, SO = SOIC. For outline information see Package Information section.

\section*{TERMINOLOGY}

\section*{Signal to (Noise + Distortion) Ratio}

This is the measured ratio of signal to (noise + distortion) at the output of the A/D converter. The signal is the rms amplitude of the fundamental. Noise is the rms sum of all nonfundamental signals up to half the sampling frequency ( \(\mathrm{f}_{\mathrm{S}} / 2\) ), excluding dc. The ratio is dependent upon the number of quantization levels in the digitization process; the more levels, the smaller the quantization noise. The theoretical signal to (noise + distortion) ratio for an ideal N -bit converter with a sine wave input is given by:
\[
\text { Signal to }(\text { Noise }+ \text { Distortion })=(6.02 N+1.76) d B
\]

Thus for a 12-bit converter, this is 74 dB .

\section*{Total Harmonic Distortion}

Total harmonic distortion (THD) is the ratio of the rms sum of harmonics to the fundamental. For the AD7893, it is defined as:
\[
T H D(d B)=20 \log \frac{\sqrt{V_{2}^{2}+V_{3}^{2}+V_{4}^{2}+V_{5}^{2}+V_{6}^{2}}}{V_{1}}
\]
where \(V_{1}\) is the rms amplitude of the fundamental and \(V_{2}, V_{3}\), \(V_{4}, V_{5}\) and \(V_{6}\) are the rms amplitudes of the second through the sixth harmonics.

\section*{Peak Harmonic or Spurious Noise}

Peak harmonic or spurious noise is defined as the ratio of the rms value of the next largest component in the ADC output spectrum (up to \(\mathrm{f}_{\mathrm{S}} / 2\) and excluding dc ) to the rms value of the fundamental. Normally, the value of this specification is determined by the largest harmonic in the spectrum, but for parts where the harmonics are buried in the noise floor, it will be a noise peak.

\section*{Intermodulation Distortion}

With inputs consisting of sine waves at two frequencies, fa and fb , any active device with nonlinearities will create distortion products at sum and difference frequencies of \(\mathrm{mfa} \pm \mathrm{nfb}\) where \(\mathrm{m}, \mathrm{n}=0,1,2,3\), etc. Intermodulation terms are those for which neither \(m\) or \(n\) are equal to zero. For example, the second order terms include ( \(\mathrm{fa}+\mathrm{fb}\) ) and ( \(\mathrm{fa}-\mathrm{fb}\) ), while the third order terms include \((2 \mathrm{fa}+\mathrm{fb}),(2 \mathrm{fa}-\mathrm{fb}),(\mathrm{fa}+2 \mathrm{fb})\) and (fa-2 fb).
The AD7893 is tested using the CCIF standard where two input frequencies near the top end of the input bandwidth are used. In this case, the second and third order terms are of different significance. The second order terms are usually distanced in frequency from the original sine waves, while the third order
terms are usually at a frequency close to the input frequencies. As a result, the second and third order terms are specified separately. The calculation of the intermodulation distortion is as per the THD specification where it is the ratio of the rms sum of the individual distortion products to the rms amplitude of the fundamental expressed in dBs.

\section*{Relative Accuracy}

Relative accuracy or endpoint nonlinearity is the maximum deviation from a straight line passing through the endpoints of the ADC transfer function.

\section*{Differential Nonlinearity}

This is the difference between the measured and the ideal 1 LSB change between any two adjacent codes in the ADC.
Positive Full-Scale Error (AD7893-10)
This is the deviation of the last code transition ( 01 . . . 110 to \(01 \ldots 111\) ) from the ideal ( \(4 \times\) REF IN -1 LSB) after the Bipolar Zero Error has been adjusted out.
Positive Full-Scale Error (AD7893-5)
This is the deviation of the last code transition (11 . . . 110 to \(11 . . .111\) ) from the ideal ( \(2 \times\) REF IN -1 LSB) after the Unipolar Offset Error has been adjusted out.

\section*{Positive Full-Scale Error (AD7893-2)}

This is the deviation of the last code transition (11 . . 110 to 11 . . . 111) from the ideal (REF IN - 1 LSB) after the Unipolar Offset Error has been adjusted out.
Bipolar Zero Error (AD7893-10)
This is the deviation of the midscale transition (all 0 s to all 1s) from the ideal 0 V (AGND).
Unipolar Offset Error (AD7893-2, AD7893-5)
This is the deviation of the first code transition ( \(00 \ldots 000\) to \(00 \ldots 001\) ) from the ideal 1 LSB.

\section*{Negative Full-Scale Error (AD7893-10)}

This is the deviation of the first code transition (10 . . 000 to \(10 \ldots 001\) ) from the ideal ( \(-4 \times\) REF IN +1 LSB ) after Bipolar Zero Error has been adjusted out.

\section*{Track/Hold Acquisition Time}

Track/Hold acquisition time is the time required for the output of the track/hold amplifier to reach its final value, within \(\pm 1 / 2 \mathrm{LSB}\), after the end of conversion (the point at which the track/hold returns to track mode). It also applies to situations where there is a step input change on the input voltage applied to the \(\mathrm{V}_{\text {IN }}\) input of the AD7893. This means that the user must wait for the duration of the track/hold acquisition time after the end of conversion or after a step input change to \(\mathrm{V}_{\mathrm{IN}}\) before starting another conversion, to ensure that the part operates to specification.

\section*{CONVERTER DETAILS}

The AD7893 is a fast, 12 -bit single supply A/D converter. It provides the user with signal scaling (AD7893-10), track/hold, A/D converter and serial interface logic functions on a single chip. The A/D converter section of the AD7893 consists of a conventional successive-approximation converter based around an R-2R ladder structure. The signal scaling on the AD7893-10 and AD7893-5 allows the part to handle \(\pm 10 \mathrm{~V}\) and 0 to +5 V input signals respectively while operating from a single +5 V supply. The AD7893-2 accepts an analog input range of 0 V to +2.5 V . The part requires an external +2.5 V reference. The reference input to the part is buffered on-chip.

A major advantage of the AD7893 is that it provides all of the above functions in an 8 -pin package, either 8 -pin mini-DIP or SOIC. This offers the user considerable spacing saving advantages over alternative solutions. The AD7893 consumes only 25 mW typical making it ideal for battery-powered applications.
Conversion is initiated on the AD7893 by pulsing the CONVST input. On the rising edge of CONVST, the on-chip track/hold goes from track to hold mode and the conversion sequence is started. The conversion clock for the part is generated internally using a laser-trimmed clock oscillator circuit. Conversion time for the AD7893 is \(6 \mu \mathrm{~s}\) and the track/hold acquisition time is \(1.5 \mu \mathrm{~s}\). To obtain optimum performance from the part, the read operation should not occur during the conversion or during 600 ns prior to the next conversion. This allows the part to operate at throughput rates up to 117 kHz and achieve data sheet specifications. The part can operate at higher throughput rates (up to 133 kHz ) with slightly degraded performance (see Timing and Control section).

\section*{CIRCUIT DESCRIPTION}

\section*{Analog Input Section}

The AD7893 is offered as three part types, the AD7893-10 which handles a \(\pm 10 \mathrm{~V}\) input voltage range, the AD7893-5 which handles a 0 to +5 V input range and the AD7893-2 which handles a 0 V to +2.5 V input voltage range.
Figure 2 shows the analog input section for the AD7893-10 and AD7893-5. The analog input range of the AD7893-10 is \(\pm 10 \mathrm{~V}\) into an input resistance of typically \(33 \mathrm{k} \Omega\). The input range on the AD7893-5 is 0 to +5 V into an input resistance of typically \(11 \mathrm{k} \Omega\). This input is benign with no dynamic charging currents as the resistor stage is followed by a high input impedance stage


Figure 2. AD7893-10/AD7893-5 Analog Input Structure
of the track/hold amplifier. For the AD7893-10, R1 \(=30 \mathrm{k} \Omega\), \(R 2=7.5 \mathrm{k} \Omega\) and R3 \(=10 \mathrm{k} \Omega\). For the AD7893-5, R1 and R3 \(=5 \mathrm{k} \Omega\) while \(R 2\) is open-circuit.
For the AD7893-10, the designed code transitions occur on successive integer LSB values (i.e., 1 LSB, 2 LSBs, 3 LSBs ...). Output coding is 2s complement binary with 1 LSB \(=\) FS/4096 \(=20 \mathrm{~V} / 4096=4.88 \mathrm{mV}\). The ideal input/output transfer function for the AD7893-10 is shown in Table I.

Table I. Ideal Input/Output Code Table for the AD7893-10
\begin{tabular}{|c|c|}
\hline Analog Input \({ }^{1}\) & Digital Output Code Transition \\
\hline +FSR/2-1 LSB \({ }^{2}\) (9.995117) & 011 . . . 110 to \(011 . \ldots 111\) \\
\hline +FSR/2 - 2 LSBs (9.990234) & 011 . . . 101 to 011 . . . 110 \\
\hline +FSR/2-3 LSBs (9.985352) & 011 . . . 100 to 011 . . . 101 \\
\hline AGND + 1 LSB (0.004883) & 000 . . . 000 to 000 . . . 001 \\
\hline AGND (0.000000) & 111 . . . 111 to 000 . . . 000 \\
\hline AGND - 1 LSB (-0.004883) & 111 . . . 110 to 111 . . . 111 \\
\hline -FSR/2 + 3 LSBs (-9.985352) & \(100 \ldots 010\) to \(100 \ldots 011\) \\
\hline -FSR/2 + 2 LSBs (-9.990234) & 100 . . 001 to 100 . . . 010 \\
\hline -FSR/2 + 1 LSB (-9.995117) & 100 . . . 000 to 100 . . 001 \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1} \mathrm{FSR}\) is full-scale range and is 20 V with \(\mathrm{REF} \mathrm{IN}=+2.5 \mathrm{~V}\).
\({ }^{2} 1 \mathrm{LSB}=\mathrm{FSR} / 4096=4.883 \mathrm{mV}\) with REF \(\mathrm{IN}=+2.5 \mathrm{~V}\).
For the AD7893-5, the designed code transitions again occur on successive integer LSB values. Output coding is straight (natural) binary with \(1 \mathrm{LSB}=\mathrm{FS} / 4096=5 \mathrm{~V} / 4096=1.22 \mathrm{mV}\). The ideal input/output transfer function for the AD7893-5 is shown in Table II.

The analog input section for the AD7893-2 contains no biasing resistors and the \(\mathrm{V}_{\mathrm{IN}}\) pin drives the input to the track/hold amplifier directly. The analog input range is 0 V to +2.5 V into a high impedance stage with an input current of less than 500 nA . This input is benign with no dynamic charging currents. Once again, the designed code transitions occur on successive integer LSB values. Output coding is straight (natural) binary with \(1 \mathrm{LSB}=\mathrm{FS} / 4096=2.5 \mathrm{~V} / 4096=0.61 \mathrm{mV}\). Table II also shows the ideal input/output transfer function for the AD7893-2.

\section*{Table II. Ideal Input/Output Code Table for AD7893-2/AD7893-5}
\begin{tabular}{|c|c|}
\hline Analog Input \({ }^{1}\) & Digital Output Code Transition \\
\hline +FSR - 1 LSB \(^{2}\) & 111 . . . 110 to 111 . . . 111 \\
\hline +FSR - 2 LSB & 111 . . . 101 to \(111 . . .110\) \\
\hline +FSR - 3 LSB & 111 . . . 100 to 111 . . . 101 \\
\hline AGND + 3 LSB & 000 . . . 010 to 000 . . . 011 \\
\hline AGND + 2 LSB & \(000 \ldots 001\) to \(000 \ldots 010\) \\
\hline AGND + 1 LSB & 000 . . . 000 to 000 . . 001 \\
\hline \multicolumn{2}{|l|}{NOTES} \\
\hline \multicolumn{2}{|l|}{\({ }^{1}\) FSR is Full Scale Range and is 5 V for AD7893-5 and 2.5 V for AD7893-2 with REF IN \(=+2.5 \mathrm{~V}\).} \\
\hline \multicolumn{2}{|l|}{\({ }^{2}{ }^{1}\) LSB \(=\) FSR/4096 and is 1.22 mV for AD7893-5 and 0.61 mV for AD7893-2 with REF IN \(=+2.5 \mathrm{~V}\).} \\
\hline
\end{tabular}

\section*{Track/Hold Section}

The track/hold amplifier on the analog input of the AD7893 allows the ADC to accurately convert an input sine wave of fullscale amplitude to 12 -bit accuracy. The input bandwidth of the track/hold is greater than the Nyquist rate of the ADC even when the ADC is operated at its maximum throughput rate of 117 kHz (i.e., the track/hold can handle input frequencies in excess of 58 kHz ).
The track/hold amplifier acquires an input signal to 12 -bit accuracy in less than \(1.5 \mu \mathrm{~s}\). The operation of the track/hold is essentially transparent to the user. The track/hold amplifier goes from its tracking mode to its hold mode at the start of conversion (i.e., the rising edge of CONVST). The aperture time for the track/hold (i.e. the delay time between the external \(\overline{\mathrm{CON}}\) VST signal and the track/hold actually going into hold) is typically 15 ns . At the end of conversion ( \(6 \mu \mathrm{~s}\) after the rising edge of CONVST) the part returns to its tracking mode. The acquisition time of the track/hold amplifier begins at this point.

\section*{Reference Input}

The reference input to the AD7893 is buffered on-chip with a maximum reference input current of \(1 \mu \mathrm{~A}\). The part is specified with a +2.5 V reference input voltage. Errors in the reference source will result in gain errors in the AD7893's transfer function and will add to the specified full-scale errors on the part. On the AD7893-10 it will also result in an offset error injected in the attenuator stage. Suitable reference sources for the AD7893 include the AD780 and AD680 precision +2.5 V references.

\section*{Timing and Control Section}

Figure 4 shows the timing and control sequence required to obtain optimum performance from the AD7893. In the sequence shown, conversion is initiated on the rising edge of CONVST and new data from this conversion is available in the output register of the AD7893 \(6 \mu \mathrm{~s}\) later. Once the read operation has taken place, a further 600 ns should be allowed before the next rising edge of CONVST to optimize the settling of the track/ hold amplifier before the next conversion is initiated. With the serial clock frequency at its maximum of 8.33 MHz , the achievable throughput rate for the part is \(6 \mu \mathrm{~s}\) (conversion time) plus \(1.92 \mu \mathrm{~s}\) (read time) plus \(0.6 \mu \mathrm{~s}\) (acquisition time). This results in a minimum throughput time of \(8.52 \mu \mathrm{~s}\) (equivalent to a throughput rate of 117 kHz ).

The read operation consists of sixteen serial clock pulses to the output shift register of the AD7893. After sixteen serial clock pulses the shift register is reset and the SDATA line is threestated. If there are more serial clock pulses after the sixteenth clock, the shift register will be moved on past its reset state. However, the shift register will be reset again on the falling edge of the CONVST signal to ensure that the part returns to a known state every conversion cycle. As a result, a read operation from the output register should not straddle across the falling middle of the read operation and the data read back into the microprocessor will appear invalid.
The throughput rate of the part can be increased by reading data during conversion or during the acquisition time. If the data is read during conversion, a throughput time of \(6 \mu \mathrm{~s}\) (conversion time) plus \(1.5 \mu \mathrm{~s}\) is achieved. This minimum throughput time of \(7.5 \mu \mathrm{~s}\) is achieved with a slight reduction in performance from the AD7893. The signal to (noise + distortion) number is likely to degrade by approximately 1.5 dB while the code flicker from the part will also increase (see AD7893 PERFORMANCE section).
Because the AD7893 is provided in an 8-pin package to minimize board space, the number of pins available for interfacing is very limited. As a result, no status signal is provided from the AD7893 to indicate when conversion is complete. In many applications this will not be a problem as the data can be read from the AD7893 during conversion or after conversion. However, applications which want to achieve optimum performance from the AD7893 will have to ensure that the data read does not occur during conversion or during 600 ns prior to the rising edge of \(\overline{\text { CONVST }}\). This can be achieved in either of two ways. The first is to ensure in software that the read operation is not initiated until \(6 \mu\) s after the rising edge of CONVST. This will only be possible if the software knows when the CONVST command is issued. The second scheme would be to use the \(\overline{\mathrm{CON}}-\) \(\overline{\mathrm{VST}}\) signal as both the conversion start signal and an interrupt signal. The simplest way to do this would be to generate a square wave signal for CONVST with high and low times of \(6 \mu \mathrm{~s}\) (see Figure 4). Conversion is initiated on the rising edge of \(\overline{\text { CONVST. The falling edge of CONVST occurs } 6 \mu \text { later }}\) and can be used as either an active low or falling edge-triggered interrupt signal to tell the processor to read the data from the


Figure 3. Timing Sequence for Optimum Performance from the AD7893


Figure 4. \(\overline{\text { CONVST Used as Status Signal }}\)

AD7893. Provided the read operation is completed 600 ns before the rising edge of CONVST, the AD7893 will operate to specification.
This scheme limits the throughput rate to \(12 \mu \mathrm{~s}\) minimum. However, depending upon the response time of the microprocessor to the interrupt signal and the time taken by the processor to read the data, this may the fastest which the system could have operated. In any case, the CONVST signal does not have to have a \(50: 50\) duty cycle. This can be tailored to optimize the throughput rate of the part for a given system.
Alternatively, the CONVST signal can be used as a normal narrow pulse width. The rising edge of CONVST can be used as an active high or rising edge-triggered interrupt. A software delay of \(6 \mu \mathrm{~s}\) can then be implemented before data is read from the part.

\section*{Serial Interface}

The serial interface to the AD7893 consists of just two wires, a serial clock input (SCLK) and the serial data output (SDATA). This allows for an easy-to-use interface to most microcontrollers, DSP processors and shift registers.
Figure 5 shows the timing diagram for the read operation to the AD7893. The serial clock input (SCLK) provides the clock source for the serial interface. Serial data is clocked out from the SDATA line on the rising edge of this clock and is valid on the falling edge of SCLK. Sixteen clock pulses must be provided to the part to access to full conversion result. The AD7893 provides four leading zeros followed by the 12 -bit conversion result starting with the MSB (DB11). The last data bit to be clocked out on the final rising clock edge is the LSB (DB0). On the six-
teenth falling edge of SCLK, the SDATA line is disabled (threestated). After this last bit has been clocked out, the SCLK input should return low and remain low until the next serial data read operation. If there are extra clock pulses after the sixteenth clock, the AD7893 will start over again with outputting data from its output register and the data bus will no longer be threestated even when the clock stops. Provided the serial clock has stopped before the next falling edge of CONVST, the AD7893 will continue to operate correctly with the output shift register being reset on the falling edge of CONVST. However, the SCLK line must be low when CONVST goes low in order to reset the output shift register correctly.
The serial clock input does not have to be continuous during the serial read operation. The sixteen bits of data (four leading zeros and 12 bit conversion result) can be read from the AD7893 in a number of bytes. However, the SCLK input must remain low between the two bytes.
Normally, the output register is updated at the end of conversion. However, if a serial read from the output register is in progress when conversion is complete, the updating of the output register is deferred. In this case, the output register is updated when the serial read is completed. If the serial read has not been completed before the next falling edge of CONVST, then the output register will be updated on the falling edge of CONVST and the output shift register count is reset. In applications where the data read has been started and not completed before the falling edge of CONVST, the user must provide a CONVST pulse width of greater than \(1.5 \mu\) s to ensure correct setup of the AD7893 before the next conversion is initiated. In


Figure 5. Data Read Operation
applications where the output update takes place either at the end of conversion or at the end of a serial read which is completed \(1.5 \mu\) s before the rising edge of CONVST, the normal pulse width of 50 ns minimum applies to \(\overline{\text { CONVST. }}\)
The AD7893 counts the serial clock edges to know which bit from the output register should be placed on the SDATA output. To ensure that the part does not lose synchronization, the serial clock counter is reset on the falling edge of the CONVST input provided the SCLK line is low. The user should ensure that a falling edge on the CONVST input does not occur, while a serial data read operation is in progress.

\section*{MICROPROCESSOR/MICROCONTROLLER INTERFACE}

The AD7893 provides a two-wire serial interface which can be used for connection to the serial ports of DSP processors and microcontrollers. Figures 6 through 9 show the AD7893 interfaced to a number of different microcontrollers and DSP processors. The AD7893 accepts an external serial clock and as a result, in all interfaces shown here, the processor/controller is configured as the master, providing the serial clock, with the AD7893 configured as the slave in the system.

\section*{AD7893-8051 Interface}

Figure 6 shows an interface between the AD7893 and the 8 XC 51 microcontroller. The 8XC51 is configured for its Mode 0 serial interface mode. The diagram shows the simplest form of the interface where the AD7893 is the only part connected to the serial port of the 8 XC 51 and, therefore, no decoding of the serial read operations is required. It also makes no provisions for monitoring when conversion is complete on the AD7893.
Either of these two tasks can readily be accomplished with minor modifications to the interface. To chip select the AD7893 in systems where more than one device is connected to the 8XC51's serial port, a port bit, configured as an output, from one of the 8XC51's parallel ports can be used to gate on or off the serial clock to the AD7893. A simple AND function on this port bit and the serial clock from the 8 XC 51 will provide this function. The port bit should be high to select the AD7893 and low when it is not selected.


Figure 6. AD7893 to 8XC51 Interface

To monitor the conversion time on the AD7893 a scheme such as outlined previously with CONVST can be used. This can be implemented in two ways. One is to connect the CONVST line to another parallel port bit which is configured as an input. This port bit can then be polled to determine when conversion is complete. An alternative is to use an interrupt driven system in which case the \(\overline{\text { CONVST }}\) line should be connected to the INT1 input of the 8XC51.
The serial clock rate from the 8 XC 51 is limited to significantly less than the allowable input serial clock frequency with which the AD7893 can operate. As a result, the time to read data from the part will actually be longer than the conversion time of the part. This means that the AD7893 cannot run at its maximum throughput rate when used with the 8 XC 51 .

\section*{AD7893-68HC11 Interface}

An interface circuit between the AD7893 and the \(68 \mathrm{HCl1}\) microcontroller is shown in Figure 7. For the interface shown, the \(68 \mathrm{HCl1}\) SPI port is used and the \(68 \mathrm{HCl1}\) is configured in its single-chip mode. The \(68 \mathrm{HCl1}\) is configured in the master mode with its CPOL bit set to a logic zero and its CPHA bit set to a logic one. As with the previous interface, the diagram shows the simplest form of the interface where the AD7893 is the only part connected to the serial port of the \(68 \mathrm{HCl1}\) and, therefore, no decoding of the serial read operations is required. It also makes no provisions for monitoring when conversion is complete on the AD7893.
Once again, either of these two tasks can readily be accomplished with minor modifications to the interface. To chip select the AD7893 in systems where more than one device is connected to the 68 HCl 1 's serial port, a port bit, configured as an output, from one of the \(68 \mathrm{HCl1}\) 's parallel ports can be used to gate on or off the serial clock to the AD7893. A simple AND function on this port bit and the serial clock from the 68 HCl 1 will provide this function. The port bit should be high to select the AD7893 and low when it is not selected.
To monitor the conversion time on the AD7893 a scheme, such as outlined in the previous interface with CONVST, can be used. This can be implemented in two ways. One is to connect the CONVST line to another parallel port bit which is configured as an input. This port bit can then be polled to determine when conversion is complete. An alternative is to use an interrupt driven system in which case the CONVST line should be connected to the \(\overline{\mathrm{IRQ}}\) input of the \(68 \mathrm{HCl1}\).


Figure 7. AD7893 to 68HC11 Interface

\section*{AD7893}

The serial clock rate from the \(68 \mathrm{HCl1}\) is limited to significantly less than the allowable input serial clock frequency with which the AD7893 can operate. As a result, the time to read data from the part will actually be longer than the conversion time of the part. This means that the AD7893 cannot run at its maximum throughput rate when used with the \(68 \mathrm{HCl1}\).

\section*{AD7893-ADSP-2105 Interface}

An interface circuit between the AD7893 and the ADSP-2105 DSP processor is shown in Figure 8. In the interface shown, the RFS1 output from the ADSP-2105's SPORT1 serial port is used to gate the serial clock (SCLK1) of the ADSP-2105 before it is applied to the SCLK input of the AD7893. The RFS1 output is configured for active high operation. The interface ensures a noncontinuous clock for the AD7893's serial clock input, with only sixteen serial clock pulses provided and the serial clock line of the AD7893 remaining low between data transfers. The SDATA line from the AD7893 is connected to the DR1 line of the ADSP-2105's serial port.


Figure 8. AD7893 to ADSP-2105 Interface
The timing relationship between the SCLK1 and RFS1 outputs of the ADSP-2105 are such that the delay between the rising edge of the SCLK1 and the rising edge of an active high RFS1 is up to 25 ns . There is also a requirement that data must be setup 10 ns prior to the falling edge of the SCLK1 to be read correctly by the ADSP-2105. The data access time for the AD7893 is 50 ns from the rising edge of its SCLK input. Assuming a 10 ns propagation delay through the external AND gate, the high time of the SCLK1 output of the ADSP-2105 must be \(\geq(50+25+10+10)\) ns, i.e., \(\geq 95\) ns. This means that the serial clock frequency with which the interface of Figure 13 can work with is limited to 5.26 MHz .

An alternative scheme is to configure the ADSP-2105 such that it accepts an external serial clock. In this case, an external noncontinuous serial clock is provided which drives the serial clock inputs of both the ADSP-2105 and the AD7893. In this scheme, the serial clock frequency is limited to 5 MHz by the ADSP-2105.
To monitor the conversion time on the AD7893 a scheme, such as outlined in previous interfaces with CONVST, can be used. This can be implemented by connecting the CONVST line directly to the \(\overline{\mathrm{IRQ}} 2\) input of the ADSP-2105.

\section*{AD7893-DSP56000 Interface}

Figure 9 shows an interface circuit between the AD7893 and the DSP56000 DSP processor. The DSP5600 is configured for normal mode asynchronous operation with gated clock. It is also set up for a 16-bit word with the gated serial clock being generated by the DSP56000 and appears on the SC0 pin. The SC0 pin should be configured as an output by setting bit SCD0 to 1 . In this mode, the DSP56000 provides sixteen serial clock pulses to the AD7893 in a serial read operation. The DSP56000 assumes valid data on the first falling edge of SCK so the interface is simply two-wire as shown in Figure 9.
To monitor the conversion time on the AD7893 a scheme, such as outlined in previous interface examples with CONVST, can be used. This can be implemented by connecting the CONVST line directly to the \(\overline{\mathrm{IRQA}}\) input of the DSP56000.


Figure 9. AD7893 to DSP56000 Interface

\section*{AD7893 PERFORMANCE}

Figure 10 shows a histogram plot for 8192 conversions of a dc input using the AD7893. The analog input was set at the center of a code transition. The timing and control sequence used was as per Figure 3 where the optimum performance of the ADC was achieved. It can be seen that almost all the codes appear in the one output bin indicating very good noise performance from the ADC. The rms noise performance for the AD7893-2 for the above plot was \(87 \mu \mathrm{~V}\). Since the analog input range, and hence LSB size, on the AD7893-10 is eight times what it is for the AD7893-2, the same output code distribution results in an output rms noise of \(700 \mu \mathrm{~V}\) for the AD7893-10.


Figure 10. Histogram of 8192 Conversions of a DC Input

\title{
3 V, LC\(^{2}\) MOS 12-Bit, Serial 8 us ADC in 8-Pin Package
}

FEATURES
Fast 12-Bit ADC with \(8 \mu \mathrm{~s}\) Conversion Time 8-Pin Mini-DIP and SOIC
Single 3 V Supply Operation
High Speed, Easy-to-Use, Serial Interface
On-Chip Track/Hold Amplifier
Analog Input Range is \(\mathbf{0} \mathbf{V}\) to \(\mathbf{V}_{\mathbf{D D}}\)
High Input Impedance
Low Power: 10 mW typ

FUNCTIONAL BLOCK DIAGRAM


\section*{PRODUCT HIGHLIGHTS}
1. Complete, 12 -bit ADC in 8 -Pin Package

The AD7896 contains an \(8 \mu \mathrm{~s}\) ADC, a track/hold amplifier, control logic and a high speed serial interface, all in an 8-pin DIP. The \(V_{D D}\) input is used as the reference for the part so no external reference is needed. This offers considerable space saying over alternative solutions.
2. Low Power, Single Supply Operation

The AD7896 operates from a single +3 V supply and consumes only 10 mW typical. The automatic power down mode, where the part goes into power down once conversion is complete and "wakes up" before the next conversion cycle, makes the AD7896 ideal for battery powered or portable applications.
3. High Speed Serial Interface

The part provides high speed serial data and serial clock lines allowing for an easy, two-wire serial interface arrangement.

\footnotetext{
*Patent pending.

This is a preliminary data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.
}
\begin{tabular}{|c|c|c|c|c|c|}
\hline Parameter & A Versions \({ }^{1}\) & B Versions & \begin{tabular}{l}
S \\
Version
\end{tabular} & Units & Test Conditions/Comments \\
\hline \begin{tabular}{l}
DYNAMIC PERFORMANCE \({ }^{2}\) \\
Signal to (Noise + Distortion) Ratio \({ }^{3}\) @ \(+25^{\circ} \mathrm{C}\) \\
\(\mathrm{T}_{\mathrm{MIN}}\) to \(\mathrm{T}_{\mathrm{MAX}}\) \\
Total Harmonic Distortion (THD) \({ }^{3}\) \\
Peak Harmonic or Spurious Noise \({ }^{3}\) Intermodulation Distortion (IMD) \({ }^{3}\) 2nd Order Terms 3rd Order Terms
\end{tabular} & \[
\begin{aligned}
& 70 \\
& -80 \\
& -80 \\
& \\
& -80 \\
& -80
\end{aligned}
\] & \[
\left\lvert\, \begin{aligned}
& 70 \\
& 70 \\
& -80 \\
& -80 \\
& \\
& -80 \\
& -80
\end{aligned}\right.
\] & \[
\begin{aligned}
& 70 \\
& -80 \\
& -80 \\
& -80 \\
& -80
\end{aligned}
\] & \begin{tabular}{l}
dB min \\
\(d B\) min \\
dB max \\
dB max \\
dB max \\
dB max
\end{tabular} & \[
\begin{aligned}
& \mathrm{f}_{\mathrm{IN}}=10 \mathrm{kHz} \text { Sine Wave, } \mathrm{f}_{\text {SAMPLE }}=100 \mathrm{kHz} \\
& \mathrm{f}_{\mathrm{IN}}=10 \mathrm{kHz} \text { Sine Wave, } \mathrm{f}_{\text {SAMPLE }}=100 \mathrm{kHz} \\
& \mathrm{f}_{\mathrm{IN}}=10 \mathrm{kHz} \text { Sine Wave, } \mathrm{f}_{\text {SAMPLE }}=100 \mathrm{kHz} \\
& \mathrm{fa}=9 \mathrm{~Hz}, \mathrm{fb}=9.5 \mathrm{kHz}, \mathrm{f}_{\text {SAMPLE }}=100 \mathrm{kHz}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
DC ACCURACY \\
Resolution \\
Minimum Resolution for which No \\
Missing Codes are Guaranteed \\
Relative Accuracy \({ }^{3}\) \\
Differential Nonlinearity \({ }^{3}\) \\
Positive Full-Scale Error \({ }^{3}\) \\
Unipolar Offset Error
\end{tabular} & \[
\begin{aligned}
& 12 \\
& 12 \\
& \pm 1 \\
& \pm 1 \\
& \pm 3 \\
& \pm 4
\end{aligned}
\] & \[
\begin{aligned}
& 12 \\
& 12 \\
& \pm 1 / 2 \\
& \pm 1 \\
& \pm 1.5 \\
& \pm 3
\end{aligned}
\] & \[
\begin{aligned}
& 12 \\
& \\
& 12 \\
& \pm 1 \\
& \pm 1 \\
& \pm 3 \\
& \pm 4
\end{aligned}
\] & \begin{tabular}{l}
Bits \\
Bits \\
LSB max \\
LSB max \\
LSB max \\
LSB max
\end{tabular} & \\
\hline ANALOG INPUT Input Voltage Range Input Current & \[
\begin{aligned}
& 0 \mathrm{~V} \text { to }+\mathrm{V}_{\mathrm{DD}} \\
& 50
\end{aligned}
\] & \[
\left\lvert\, \begin{aligned}
& 0 \mathrm{~V} \text { to }+\mathrm{V}_{\mathrm{DD}} \\
& 50
\end{aligned}\right.
\] & \[
\begin{aligned}
& 0 \mathrm{~V} \text { to }+\mathrm{V}_{\mathrm{DD}} \\
& 50
\end{aligned}
\] & Volts \(\mu \mathrm{A}\) max &  \\
\hline \begin{tabular}{l}
LOGIC INPUTS \\
Input High Voltage, \(\mathbf{V}_{\text {INH }}\) Input Low Voltage, \(\mathrm{V}_{\text {INL }}\) Input Current, \(\mathrm{I}_{\text {IN }}\) Input Capacitance, \(\mathrm{C}_{\mathrm{IN}}{ }^{4}\)
\end{tabular} & \[
\begin{aligned}
& 2.0 \\
& 0.8 \\
& \pm 10 \\
& 10
\end{aligned}
\] & \[
\begin{aligned}
& 2.0 \\
& 0.8 \\
& \pm 10 \\
& 10
\end{aligned}
\] & \begin{tabular}{l}
2.0 \\
0.8 \\
\(\pm 10\) \\
10
\end{tabular} & \begin{tabular}{l}
\(V\) min \\
\(V_{\text {max }}\) \\
MA max \\
pF max
\end{tabular} & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V} \text { to } 3.6 \mathrm{~V} \\
& \mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{DD}}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
LOGIC OUTPUTS \\
Output High Voltage, \(\mathrm{V}_{\mathrm{OH}}\) Output Low Voltage, \(\mathrm{V}_{\mathrm{OL}}\) Output Coding
\end{tabular} & \[
\begin{aligned}
& 2.4 \\
& 0.4 \\
& \\
& \text { Straight }
\end{aligned}
\] & \begin{tabular}{l}
\[
2.4
\] \\
0.4 \\
Natural) Bin
\end{tabular} & \begin{tabular}{l}
2.4 \\
0.4 .
\end{tabular} & \begin{tabular}{l}
\(V\) min \\
V max
\end{tabular} & \[
\begin{aligned}
& \mathrm{I}_{\text {SOURCE }}=2 \mathrm{~mA} \\
& \mathrm{I}_{\text {SINK }}=2 \mathrm{~mA}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
CONVERSION RATE \\
Conversion Time: \\
Mode 1 Operation \\
Mode 2 Operation \({ }^{5}\) \\
Track/Hold Acquisition Time \({ }^{3}\)
\end{tabular} & \[
\begin{array}{|l}
8 \\
13 \\
1.5
\end{array}
\] & \[
\begin{array}{|l}
8 \\
13 \\
1.5
\end{array}
\] & \[
\begin{aligned}
& 8 \\
& 13 \\
& 1.5
\end{aligned}
\] & \(\mu \mathrm{s}\) max \(\mu \mathrm{s} \max\) \(\mu \mathrm{s}\) max & \\
\hline \begin{tabular}{l}
POWER REQUIREMENTS \\
\(V_{D D}\) \\
\(I_{D D}\) \\
Power Dissipation \\
Power-Down Mode \\
\(\mathrm{I}_{\mathrm{DD}}\) \\
Power Dissipation
\end{tabular} & \[
\begin{aligned}
& +3.0 /+3.6 \\
& 4.5 \\
& 15 \\
& 10 \\
& 36
\end{aligned}
\] & \[
\begin{aligned}
& +3.0 /+3.6 \\
& 4.5 \\
& 15 \\
& 10 \\
& 36
\end{aligned}
\] & \[
\begin{aligned}
& +3.0 /+3.6 \\
& 4.5 \\
& 15 \\
& 10 \\
& 36
\end{aligned}
\] & \begin{tabular}{l}
V min/max \(m A\) max mW max \\
\(\mu \mathrm{A}\) max \(\mu \mathrm{W}\) max
\end{tabular} & \(\mathrm{V}_{\mathrm{DD}}=3.3 \mathrm{~V}\), Typically 10 mW \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Temperature ranges are as follows: A, B Versions: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\); S Version: \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\).
\({ }^{2}\) Applies to Mode 1 operation. See section on operating modes.
\({ }^{3}\) See Terminology.
\({ }^{4}\) Sample tested @ \(+25^{\circ} \mathrm{C}\) to ensure compliance.
\({ }^{5}\) This \(13 \mu \mathrm{~s}\) includes the "wake-up" time from standby. This "wake-up" time is timed from the rising edge of CONVST, whereas conversion is timed from the falling edge of \(\overline{\text { CONVST }}\), for narrow \(\overline{\text { CONVST }}\) pulse width the conversion time is effectively the "wake-up" time plus conversion time hence \(13 \mu \mathrm{~s}\). This can be seen from Figure 3. Note that if the CONVST pulse width is greater than \(5 \mu \mathrm{~s}\) then the effective conversion time will increase beyond \(13 \mu \mathrm{~s}\).

Specifications subject to change without notice.

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TIMING CHARACTERISTICS \({ }^{1}\left(\mathrm{~V}_{00}=+3.0 \mathrm{~V}\right.\) to \(\left.+3.6 \mathrm{~V}, \mathrm{aGNO}=\mathrm{oGNO}=0 \mathrm{~V}\right)\)
\begin{tabular}{l|l|l|l|l}
\hline Parameter & \begin{tabular}{l} 
A, B \\
Versions
\end{tabular} & \begin{tabular}{l} 
S \\
Version
\end{tabular} & Units & Test Conditions/Comments \\
\hline \(\mathrm{t}_{1}\) & 50 & 50 & ns min & CONVST Pulse Width \\
\(\mathrm{t}_{2}\) & 50 & 50 & ns min & SCLK High Pulse Width \\
\(\mathrm{t}_{3}\) & 50 & 50 & ns min & SCLK Low Pulse Width \\
\(\mathrm{t}_{4}\) & \(80^{2}\) & \(80^{2}\) & ns max & Data Access Time After Falling Edge of SCLK \\
\(\mathrm{t}_{5}\) & 15 & 15 & ns min & Data Hold Time After Falling Edge of SCLK \\
\(\mathrm{t}_{6}\) & \(100^{3}\) & \(100^{3}\) & ns max & Bus Relinquish Time After Falling Edge of SCLK \\
\hline
\end{tabular}

NOTES
\({ }^{1}\) Sample tested at \(+25^{\circ} \mathrm{C}\) to ensure compliance. All input signals are measured with \(\mathrm{tr}=\mathrm{tf}=1 \mathrm{~ns}(10 \%\) to \(90 \%\) of \(+3.3 \mathrm{~V})\) and timed from a voltage level of +1.6 V .
\({ }^{2}\) Measured with the load circuit of Figure 1 and defined as the time required for an output to cross 0.8 V or 2.0 V .
\({ }^{3}\) Derived from the measured time taken by the data outputs to change 0.5 V when loaded with the circuit of Figure 1 . The measured number is then extrapolated back to remove the effects of charging or discharging the 50 pF capacitor. This means that the time, \(\mathrm{t}_{6}\), quoted in the timing characteristics is the true bus relinquish time of the part and as such is independent of external bus loading capacitances.

\section*{ABSOLUTE MAXIMUM RATINGS*}
\begin{tabular}{|c|c|}
\hline \multicolumn{2}{|l|}{( \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) unless otherwise noted)} \\
\hline \(\mathrm{V}_{\mathrm{DD}}\) to AGND & -0.3 V to +7 V \\
\hline \(\mathrm{V}_{\mathrm{DD}}\) to DGND. & -0.3 V to +7 V \\
\hline Analog Input Voltage to AGND & -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\) \\
\hline Digital Input Voltage to DGND & -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\) \\
\hline Digital Output Voltage to DGND & -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\) \\
\hline \multicolumn{2}{|l|}{Operating Temperature Range} \\
\hline Commercial (A, B Versions) & \(40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) \\
\hline Extended (S Version) & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) \\
\hline \multicolumn{2}{|l|}{Storage Temperature Range} \\
\hline \multicolumn{2}{|l|}{Junction Temperature . . . . . . . . . . . . . . . . . . . . . \(+150^{\circ} \mathrm{C}\)} \\
\hline \multicolumn{2}{|l|}{Plastic DIP Package, Power Dissipation} \\
\hline \(\theta_{\mathrm{JA}}\) Thermal Impedance & \(125^{\circ} \mathrm{C} / \mathrm{W}\) \\
\hline \(\theta_{\text {JC }}\) Thermal Impedance. & \(50^{\circ} \mathrm{C} / \mathrm{W}\) \\
\hline Lead Temperature (Soldering, 10 sec ) & \(+260^{\circ} \mathrm{C}\) \\
\hline SOIC Package, Power Dissipation & 450 mW \\
\hline \(\theta_{\mathrm{JA}}\) Thermal Impedance & \(160^{\circ} \mathrm{C} / \mathrm{W}\) \\
\hline \(\theta_{\text {JC }}\) Thermal Impedance & \(75^{\circ} \mathrm{C} / \mathrm{W}\) \\
\hline \multicolumn{2}{|l|}{Lead Temperature, Soldering} \\
\hline Vapor Phase (60 sec) & \(+215^{\circ} \mathrm{C}\) \\
\hline Infrared (15 sec) & \(+220^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD7896 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.
\begin{tabular}{|c|c|c|}
\hline \begin{tabular}{l}
Pin \\
No.
\end{tabular} & \begin{tabular}{l}
Pin \\
Mnemonic
\end{tabular} & Description \\
\hline 1 & \(\mathrm{V}_{\text {IN }}\) & Analog Input. The analog input range is 0 V to \(\mathrm{V}_{\mathrm{DD}}\). \\
\hline 2 & \(V_{\text {DD }}\) & Positive supply voltage, +3.0 V to 3.6 V . \\
\hline 3 & AGND & Analog Ground. Ground reference for track/hold, comparator and DAC. \\
\hline 4 & SCLK & Serial Clock Input. An external serial clock is applied to this input to obtain serial data from the AD7896. A new serial data bit is clocked out on the falling edge of this serial clock. Data is guaranteed valid for 15 ns after this falling edge so the \(\mu \mathrm{P}\) can accept data on the either the falling edge or the rising edge. The serial clock input should be taken low at the end of the serial data transmission. \\
\hline 5 & SDATA & Serial Data Output. Serial data from the AD7896 is provided at this output. The serial data is clocked out by the falling edge of SCLK, but the data can also be read on the falling edge of the SCLK. This is possible because data bit N is valid for a specified time after the falling edge of the SCLK (data hold time) and can be read before data bit \(\mathrm{N}+1\) becomes valid a specified time after the falling edge of SCLK (data access time) (see Figure 4). Sixteen bits of serial data are provided with four leading zeros followed by the 12-bits of conversion data. On the sixteenth falling edge of SCLK, the SDATA line is held for the data hold time and then disabled (three-stated). Output data coding is straight binary. \\
\hline 6 & DGND & Digital Ground. Ground reference for digital circuitry . \\
\hline 7 & CONVST & Convert Start. Edge-triggered logic input. On the falling edge of this input, the track/hold goes into its hold mode and conversion is initiated. If CONVST is low at the end of conversion, the part goes into power down mode. In this case, the rising edge of CONVST "wakes up" the part. \\
\hline 8 & BUSY & The BUSY pin is used to indicate when the part is doing a conversion. The BUSY pin will go high on the falling edge of CONVST and will return low when the conversion is complete. \\
\hline
\end{tabular}

PIN CONFIGURATION


ORDERING GUIDE
\begin{tabular}{l|l|l|l|l}
\hline Model & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Linearity \\
Error (LSB)
\end{tabular} & \begin{tabular}{l} 
SNR \\
(dB)
\end{tabular} & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD7896AN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & 70 dB & \(\mathrm{~N}-8\) \\
AD7896BN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & 72 dB & \(\mathrm{~N}-8\) \\
AD7896AQ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & 70 dB & \(\mathrm{Q}-8\) \\
AD7896BQ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & 72 dB & \(\mathrm{Q}-8\) \\
AD7896AR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & 70 dB & \(\mathrm{R}-8\) \\
AD7896BR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & 72 dB & \(\mathrm{R}-8\) \\
AD7896SQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & 70 dB & \(\mathrm{Q}-8\) \\
\hline
\end{tabular}
* \(\mathrm{N}=\) Plastic DIP; \(\mathrm{Q}=\) Cerdip; \(\mathrm{R}=\) SOIC. For outline information see Package Information section.

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\section*{TERMINOLOGY}

\section*{Relative Accuracy}

This is the maximum deviation from a straight line passing through the endpoints of the ADC transfer function. The endpoints of the transfer function are zero scale (which is \(V_{I N}=\) \(A G N D+1 / 2 L S B\) ) a point \(1 / 2\) LSB below the first code transition ( \(00 \ldots 000\) to \(00 \ldots 001\) ) and full scale (which is \(V_{I N}=\) \(A G N D+V_{D D^{-}} 1 / 2 L S B\) ), a point \(1 / 2\) LSB above the last code transition (11... 110 to \(11 \ldots 111\) ).

\section*{Differential Nonlinearity}

This is the difference between the measured and the ideal 1 LSB change between any two adjacent codes in the ADC.

\section*{Unipolar Offset Error}

This is the deviation of the first code transition ( 00 . . 000 to \(00 \ldots 001\) ) from the ideal \(\mathrm{V}_{\text {IN }}\) voltage (AGND + 1 LSB ).

\section*{Positive Full-Scale Error}

This is the deviation of the last code transition ( \(11 \ldots 110\) to \(11 \ldots 111\) from the ideal ( \(\mathrm{V}_{\mathrm{IN}}=\mathrm{AGND}+\mathrm{V}_{\mathrm{DD}}-1 \mathrm{LSB}\) ) after the offset error has been adjusted out.

\section*{Track/Hold Acquisition Time}

Track/hold acquisition time is the time required for the output of the track/hold amplifier to reach its final value, within \(\pm 1 / 2\) LSB, after the end of conversion (the point at which the track/hold returns into track mode). It also applies to a situation where there is a step input change on the input voltage applied to the selected \(\mathrm{V}_{\text {IN }}\) input of the AD7896. It means that the user must wait for the duration of the track/hold acquisition time after the end of conversion or after a step input change to \(\mathrm{V}_{\mathrm{iN}}\) before starting another conversion, to ensure the part operates to specification.

\section*{Signal to (Noise + Distortion) Ratio}

This is the measured ratio of signal to (noise + distortion) at the output of the \(\mathrm{A} / \mathrm{D}\) converter. The signal is the rms amplitude of the fundamental. Noise is the sum of all nonfundamental signals up to half the sampling frequency ( \(\mathrm{f}_{\mathrm{s}} / 2\) ), excluding dc. The ratio is dependent on the number of quantization levels in the digitization process; the more levels, the smaller the quantization noise. The theoretical signal to (noise + distortion) ratio for an ideal N -bit converter with a sine wave input is given by:
\[
\text { Signal to }(\text { Noise }+ \text { Distortion })=(6.02 N+1.76) d B
\]

Thus for a 12-bit converter, this is 74 dB .

\section*{Total Harmonic Distortion}

Total harmonic distortion (THD) is the ratio of the rms sum of harmonics to the fundamental. For the AD7896, it is defined as:
\[
T H D(d B)=20 \log \frac{\sqrt{V_{2}^{2}+V_{3}^{2}+V_{4}^{2}+V_{5}^{2}+V_{6}^{2}}}{V_{1}}
\]
where \(V_{1}\) is the rms amplitude of the fundamental and \(V_{2}, V_{3}\), \(V_{4}, V_{5}\) and \(V_{6}\) are the rms amplitudes of the second through the sixth harmonics.

\section*{Peak Harmonic or Spurious Noise}

Peak harmonic or spurious noise is defined as the ratio of the rms value of the next largest component in the ADC output spectrum (up to \(\mathrm{f}_{\mathrm{S}} / 2\) and excluding dc) to the rms value of the fundamental. Normally, the value of this specification is determined by the largest harmonic in the spectrum, but for parts where the harmonics are buried in the noise floor, it will be a noise peak.

\section*{Intermodulation Distortion}

With inputs consisting of sine waves at two frequencies, fa and fb , any active device with nonlinearities will create distortion products at sum and difference frequencies of \(\mathrm{mfa} \pm \mathrm{nfb}\) where \(\mathbf{m}, \mathbf{n}=0,1,2,3\), etc. Intermodulation distortion terms are those for which neitherm nor n are equal to zero. For example, the second order terms include ( \(\mathrm{fa}+\mathrm{fb}\) ) and ( \(\mathrm{fa}-\mathrm{fb}\) ), while the third order terms include \((2 f a+f b),(2 f a-f b),(f a+2 f b)\) and \((f a-2 \mathrm{~b})\).
The AD7896 is tested using the CCIF standard where two input frequencies near the top end of the input bandwidth are used. In this case, the second order terms are usually distanced in frequency from the original sine waves while the third order terms are usually at a frequency close to the input frequencies. As a result, the second and third order terms are specified separately. The calculation of the intermodulation distortion is as per the THD specification where it is the ratio of the rms sum of the individual distortion products to the rms amplitude of the fundamental expressed in dBs .

\section*{OPERATING MODES}

\section*{Mode 1 Operation (High Sampling Performance)}

The timing diagram in Figure 2 is for optimum performance in Operating Mode 1 where the falling edge of CONVST starts conversion and puts the Track/Hold amplifier into its hold mode. This falling edge of CONVST also causes the BUSY signal to go high to indicate that a conversion is taking place. The BUSY signal goes low when the conversion is complete which is \(8 \mu \mathrm{~s}\) max after the falling edge of CONVST, and new data from this conversion is available in the output register of the AD7896.

A read operation accesses this data. This read operation consists of 16 clock cycles, and the length of this read operation will depend on the serial clock frequency. For the fastest throughput rate (with a serial clock of 10 MHz ) the read operation will take \(1.6 \mu \mathrm{~s}\). The read operation must be complete at least 400 ns before the falling edge of the next CONVST, and this gives a total time of \(10 \mu \mathrm{~s}\) for the full throughput time (equivalent to 100 kHz ). This mode of operation should be used for high sampling applications.


Figure 2. Mode 1 Timing Operation Diagram for High Sampling Performance

\section*{Mode 2 Operation (Auto Sleep After Conversion)}

The timing diagram in Figure 3 is for optimum performance in Operating Mode 2 where the part automatically goes into sleep mode once BUSY goes low after conversion and "wakes up" before the next conversion takes place. This is achieved by keeping CONVST low at the end of conversion whereas it was high at the end of conversion for Mode 1 operation. The rising edge of CONVST "wakes up" the part. This wake-up time is \(5 \mu \mathrm{~s}\) at which point the Track/Hold amplifier goes into its hold mode. The conversion takes \(8 \mu \mathrm{~s}\) after this, provided the CONVST has gone low, giving a total of \(13 \mu \mathrm{~s}\) from the rising edge of CONVST to the conversion being complete which is indicated by the BUSY going low. Note that since the wake-up time from the rising edge of \(\overline{\text { CONVST }}\) is \(5 \mu \mathrm{~s}\), when the \(\overline{\text { CONVST }}\) pulse width is greater than \(5 \mu \mathrm{~s}\) the conversion will take more than the
\(13 \mu \mathrm{~s}\) shown in diagram from the rising edge of CONVST. This is because the Track/Hold amplifier goes into its hold mode on the falling edge of CONVST and then the conversion will not be complete for a further \(8 \mu \mathrm{~s}\). In this case the BUSY will be the best indicator for when the conversion is complete. Even though the part is in sleep mode, data can still be read from the part. The read operation consists of 16 clock cycles as in Mode 1 operation. For the fastest serial clock of 10 MHz the read operation will take \(1.6 \mu \mathrm{~s}\), and this must be complete at least 400 ns before the falling edge of the next CONVST to allow the Track/ Hold amplifier to have enough time to settle. This mode is very useful when the part is converting at a slow rate as the power consumption will be significantly reduced from that of Mode 1 operation.


Figure 3. Mode 2 Timing Diagram Where Automatic Sleep Function Is Initiated

\footnotetext{
This information applies to a product under development. Its characteristics and specifications are subject to change without notice.
Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.
}

High Speed
\(\square\)
AD9000

\section*{FEATURES}

77MSPS Encode Rate
Bipolar Input Range
Low Error Rate
Overflow Bit
MIL-STD-883 Compliant Versions Available

\section*{APPLICATIONS}

QAM Telecommunications
Electronic Warfare (ECM, ECCM, ESM)
Radar Guidance Digitizers

FUNCTIONAL BLOCK DIAGRAM


The AD9000 is offered as both an commercial temperature range device 0 to \(+70^{\circ} \mathrm{C}\), and as an extended temperature range device \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\). Both versions are available packaged in a 16 -pin ceramic DIP. The extended temperature range device is also available in a 28 -pin ceramic LCC package. The extended temperature range versions are offered as fully compliant MIL-STD-883 Class B devices.

ORDERING GUIDE
\begin{tabular}{l|l|l|l}
\hline Model \(^{\mathbf{1}}\) & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD9000JD & 0 to \(+70^{\circ} \mathrm{C}\) & 16-Pin DIP, Industrial & D-16 \\
AD9000SD & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 16-Pin DIP & D-16 \\
AD9000SE & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 28-Pin LCC & E-28A \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) MIL-STD-883 versions available, contact factory.
\({ }^{2}\) D = Ceramic DIP; E = Leadless Ceramic Chip Carrier. For outline information see Package Information section.

This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

\section*{GENERAL DESCRIPTION}

The AD9000 is a 6-bit, high speed, analog-to-digital converter with ECL compatible outputs and a bipolar input stage. The AD9000 is fabricated in a high-performance bipolar process which allows encode rates up to 77MSPS.

The AD9000 employs the standard flash converter architecture based on 64 individual comparators which simultaneously determine the precise analog signal level. The comparators are followed by two stages of decoding logic, allowing the AD9000 to operate with a very low error rate. The low 35pF input capacitance of the AD9000 greatly simplifies the analog driver stage. Also incorporated into the AD9000 design is an overflow output bit as well as a hysteresis control pin to modify comparator sensitivity.

PIN DESIGNATIONS


NC = NOCONNECT

\section*{AD9000-SPECIFICATIONS}

ELECTRICAL CHARACTERISTICS (Supply Voltages \(=-5.2 \mathrm{~V}\) and +5.0 V ; Differential Reference Voltage othenwise stated) 2.20 y
\begin{tabular}{|c|c|c|c|c|c|c|c|c|}
\hline Parameter & Temp & Min &  & Max & Min &  & & Units \\
\hline RESOLUTION & & 6 & & & 6 & & & Bits \\
\hline DCACCURACY & & & & & & & \% & \\
\hline Differential Linearity & \(+25^{\circ} \mathrm{C}\) & & 0.25 & 0.5 & & 0.25 & 0.5 & LSB \\
\hline & Full & & & 1.0 & & . & 1.0 & LSB \\
\hline Integral Linearity & \(+25^{\circ} \mathrm{C}\) & & 0.25 & 0.5 & & 0.25 & 0.5 & LSB \\
\hline & Full & & & 1.0 & & & 1.0 & LSB \\
\hline No Missing Codes & Full & . & & ANTE & & & NTEE & \\
\hline INITIAL OFFSET ERROR & & & & & & & & \\
\hline Top of Reference Ladder & \(+25^{\circ} \mathrm{C}\) & & 0.3 & 7/8 & & 0.3 & 7/8 & LSB \\
\hline & Full & & & 1.5 & & & 1.5 & LSB \\
\hline Bottom of Reference Ladder & \(+25^{\circ} \mathrm{C}\) & & 0.25 & 7/8 & & 0.25 & \(7 / 8\) & LSB \\
\hline & Full & & & 1.5 & & & 1.5 & LSB \\
\hline Offset Drift Coefficient & Full & & 145 & & & 145 & & \(\mu \mathrm{V} /{ }^{\circ} \mathrm{C}\) \\
\hline ANALOG INPUT & & & & & & & & \\
\hline Input Voltage Range & Full & & \(\pm 2.0 \mathrm{~V}\) & & & \(\pm 2.0 \mathrm{~V}\) & & V \\
\hline Input Bias Current (Sampling) \({ }^{5}\) & Full & & & 800 & & & 800 & \(\mu \mathrm{A}\) \\
\hline Input Bias Current (Latched) \({ }^{5}\) & Full & & & 20 & & & 20 & \(\mu \mathrm{A}\) \\
\hline Input Resistance & \(+25^{\circ} \mathrm{C}\) & & 3.0 & & & 3.0 & & k \(\Omega\) \\
\hline Input Capacitance & \(+25^{\circ} \mathrm{C}\) & & 35 & 50 & & 35 & 50 & pF \\
\hline Full Power Bandwidth \({ }^{6}\) & \(+25^{\circ} \mathrm{C}\) & & 20 & & & 20 & & MHz \\
\hline REFERENCE INPUT \({ }^{2,3}\) & & & & & & \% & & \\
\hline Reference Ladder Resistance & \(+25^{\circ} \mathrm{C}\) & 80 & & 200 & 80 & & 200 & \(\Omega\) \\
\hline Ladder Temperature Coefficient & & & 0.275 & & & 0.275 & & \(\Omega /{ }^{\circ} \mathrm{C}\) \\
\hline Reference Input Bandwidth & \(+25^{\circ} \mathrm{C}\) & & 20 & & & 20 & & MHz \\
\hline DYNAMIC PERFORMANCE \({ }^{7}\) & & & & & & & : & \\
\hline Conversion Rate & \(+25^{\circ} \mathrm{C}\) & 50 & 70 & & 75 & 77 & & MHz \\
\hline Conversion Time (+1 Clock) & \(+25^{\circ} \mathrm{C}\) & & & 20 & & & 13.3 & \\
\hline Aperture Delay ( \(\mathrm{t}_{\mathrm{D}}\) ) & \(+25^{\circ} \mathrm{C}\) & & 2 & +..* & \% & 2 & & ns \\
\hline Aperture Uncertainty (Jitter) & \(+25^{\circ} \mathrm{C}\) & & 25 & \% & & 25 & & ps \\
\hline Output Propagation Delay ( tPD\()^{8}\) & \(+25^{\circ} \mathrm{C}\) & 8 & & 12 & 8 & & 12 & ns \\
\hline Output Hold Time ( \(\left.\mathrm{t}_{\mathrm{OH}}\right)^{9}\). & + \(25^{\circ} \mathrm{C}\) & 8 & & 14 & 8 & & 14 & ns \\
\hline Transient Response \({ }^{10}\) & \(+25^{\circ} \mathrm{C}\) & & 13 & & & 13 & & ns \\
\hline Overvoltage Recovery Time \({ }^{11}\) & \(+25^{\circ} \mathrm{C}\) & & 11 & & & 11 & & ns \\
\hline Output Rise Time \({ }^{12}\) & \(+25^{\circ} \mathrm{C}\) & & & 5.0 & & & 4.5 & ns \\
\hline Output Fall Time \({ }^{12}\) & \(+25^{\circ} \mathrm{C}\) & & & 5.0 & & & 4.5 & ns \\
\hline Output Time Skew & \(+25^{\circ} \mathrm{C}\) & & 0.4 & & & 0.4 & & ns \\
\hline ENCODE INPUT & & & & & & & & \\
\hline Logic " 1 " Voltage & Full & \(-1.1\) & & & -1.1 & & & V \\
\hline Logic "0" Voltage & Full & & & -1.5 & & & -1.5 & V \\
\hline Logic " 1 " Current & Full & & & 100 & \% & & 100 & \(\mu \mathrm{A}\) \\
\hline Logic "0" Current & Full & & & 100 & \(\cdots\) & & 100 & \(\mu \mathrm{A}\) \\
\hline Input Capacitance & \(+25^{\circ} \mathrm{C}\) & & 2.5 & 5.0 & & 2.5 & 5.0 & pF \\
\hline ENCODE Pulse Width High ( \(\mathrm{t}_{\text {PwH }}\) ) & \(+25^{\circ} \mathrm{C}\) & 6.6 & & & 6.6 & & & ns \\
\hline ENCODE Pulse Width Low ( \(\mathrm{t}_{\text {PwL }}\) ) & \(+25^{\circ} \mathrm{C}\) & 6.6 & & & 6.6 & & & ns \\
\hline
\end{tabular}

ELECTRICAL CHARACTERISTICS (cominuave)


\section*{NOTES}
\({ }^{1} \mathrm{~A}_{\text {IN }}=+\mathrm{V}_{\text {REF }}\).
\({ }^{2}\) Determined by 3 dB reduction in reconstructed output at 75MSPS.
\({ }^{3}\) Under normal operating conditions, the analog input voltages should not exceed nominal \(\pm 2 \mathrm{~V}\) operating range, nor the supply voltages
\(\left(+V_{s}\right.\) and \(\left.-V_{S}\right)\), whichever is smaller.
\({ }^{4}\) Under normal operating conditions the differential reference voltage may range from \(\pm 0.5 \mathrm{~V}\) to \(\pm 2 \mathrm{~V} ;+\mathrm{V}_{\mathrm{REF}} \geqslant-\mathrm{V}_{\mathrm{REF}}\).
\({ }^{5}\) Output terminated with \(100 \Omega\) resistors to -2.0 V .
\({ }^{6}\) Measured from the leading edge of ENCODE to data out on Bit 1 (MSB).
\({ }^{7}\) Measured from the trailing edge of ENCODE to data out on Bit 1 (MSB).
\({ }^{8}\) For full-scale step input, 6 -bit accuracy is attained in specified time.
\({ }^{9}\) Recovers to 6 -bit accuracy in specified time, after \(150 \%\) full-scale input overvoltage.
\({ }^{10}\) Measured on Bit 1 (MSB) only.
\({ }^{11}\) Measured at 50 MSPS encode rate.
\({ }^{12}\) Analog input frequency \(=15 \mathrm{MHz}\).
\({ }^{13}\) RMS signal to RMS noise, with 540 kHz analog input signal.
\({ }^{14}\) Peak-to-peak signal to rms noise, with 540 kHz analog input signal.
\({ }^{15} \mathrm{f}_{1}=9.3 \mathrm{MHz} ; \mathrm{f}_{2}=7.6 \mathrm{MHz} ;\) Encode \(=42 \mathrm{MHz}\).
\({ }^{16} \mathrm{DC}\) to 8.2 MHz noise bandwidth with 3.886 MHz slot.
\({ }^{17}\) Supply voltage should remain stable within \(\pm 5 \%\) for normal operation. Specifications subject to change without notice.

\section*{ABSOLUTE MAXIMUM RATINGS \({ }^{1}\)}
Positive Supply Voltage . . . . . . . . . . . . -0.3 V to +6 V
Negative Supply Voltage . . . . . . . . . . -6.0 V to +0.3 V

Analog-to-Digital Ground Voltage Differential . . . . . . . 0.5
Analog Input Voltages ( \(\left.\mathrm{A}_{\mathrm{IN}},+\mathrm{V}_{\mathrm{REF}},-\mathrm{V}_{\mathrm{REF}}\right)^{2} \ldots \ldots+3 \mathrm{~V}\)
Differential Reference Voltage \(\left(+\mathrm{V}_{\mathrm{REF}} \text { to }-\mathrm{V}_{\mathrm{REF}}\right)^{3}\). . . . 6 V
ENCODE Input Voltage . . . . . . . . . . . . . \(-V_{\text {s }}\) to 0V
HYSTERESIS Control Voltage . . . . . . . . . \(0 V\) to +3.0 V
Digital Output Current . . . . . . . . . . . . . . . . . 20mA
Power Dissipation ( \(+25^{\circ} \mathrm{C}\) Free Air) \()^{4}\). . . . . . . . . 745 mW
Operating Temperature Range
AD9000JD . . . . . . . . . . . . . . . . . . . 0 to \(+70^{\circ} \mathrm{C}\)
AD9000SD/SE . . . . . . . . . . . . . \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
Storage Temperature Range . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Junction Temperature . . . . . . . . . . . . . . . \(+175^{\circ} \mathrm{C}\)
Lead Soldering Temperature ( 10 sec) . . . . . . . . . \(+300^{\circ} \mathrm{C}\)

\footnotetext{
NOTES
\({ }^{1}\) Absolute maximum ratings are limiting values, to be applied individually, and beyond which serviceability of the circuit may be impaired. Functional operability under any of these conditions is not necessarily implied.
Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
\({ }^{2}\) Under normal operating conditions, the analog input voltages should not exceed nominal \(\pm 2 \mathrm{~V}\) operating range, nor the supply voltages
\(\left(+V_{S}\right.\) and \(\left.-V_{S}\right)\), whichever is smaller.
\({ }^{3}\) Under normal operating conditions the differential reference voltage may range from \(\pm 0.5 \mathrm{~V}\) to \(\pm 2 \mathrm{~V} ;+\mathrm{V}_{\mathrm{REF}} \geqslant-\mathrm{V}_{\mathrm{REF}}\).
\({ }^{4}\) Typical thermal impedances . . .
\[
\begin{array}{ll}
\text { 16-Pin Ceramic } & \theta_{\text {ja }}=67^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{ic}}=7^{\circ} \mathrm{C} / \mathrm{W} \\
\text { 28-Pin LCC } & \theta_{\mathrm{ja}}=62^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{jc}}=14^{\circ} \mathrm{C} / \mathrm{W}
\end{array}
\]
}

\section*{FEATURES}

150MSPS Encode Rate
Low Input Capacitance: 17pF
Low Power: 750mW
-5.2V Single Supply
MIL-STD-883 Compliant Versions Available

\section*{APPLICATIONS}

Radar Systems
Digital Oscilloscopes/ATE Equipment
Laser/Radar Warning Receivers
Digital Radio
Electronic Warfare (ECM, ECCM, ESM)
Communication/Signal Intelligence

\section*{GENERAL DESCRIPTION}

The AD9002 is an 8-bit, high speed, analog-to-digital converter. The AD9002 is fabricated in an advanced bipolar process which allows operation at sampling rates in excess of 150 megasamples/ second. Functionally, the AD9002 is comprised of 256 parallel comparator stages whose outputs are decoded to drive the ECL compatible output latches.
An exceptionally wide large signal analog input bandwidth of 160 MHz is due to an innovative comparator design and very close attention to device layout considerations. The wide input bandwidth of the AD9002 allows very accurate acquisition of high speed pulse inputs, without an external track-and-hold. The comparator output decoding scheme minimizes false codes which is critical to high speed linearity.
The AD9002 provides an external hysteresis control pin which can be used to optimize comparator sensitivity to further improve performance. Additionally, the AD9002's low power dissipation of 750 mW makes it usable over the full extended temperature

\section*{FUNCTIONAL BLOCK DIAGRAM}

range. The AD9002 also incorporates an overflow bit to indicate overrange inputs. This overflow output can be disabled with the overflow inhibit pin.

The AD9002 is available in two grades, one with 0.5LSB linearity and one with 0.75 LSB linearity. Both versions are offered in an industrial grade, \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\), packaged in a 28 -pin DIP and a 28 -pin JLCC. The military temperature range devices, \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\), are available in ceramic DIP and LCC packages and are compliant to MIL-STD-883 Class B.

\section*{ABSOLUTE MAXIMUM RATINGS \({ }^{1}\)}

Supply Voltage ( \(-\mathrm{V}_{\mathrm{S}}\) )
\(-6 \mathrm{~V}\)
Analog-to-Digital Supply Voltage Differential0.5 V

Analog Input Voltage . . . . . . . . . . . . . . . . \(-V_{S}\) to +0.5 V
Digital Input Voltage \(-V_{S}\) to 0 V
Reference Input Voltage \(\left(+\mathrm{V}_{\mathrm{REF}}-\mathrm{V}_{\mathrm{REF}}\right)^{2} .-3.5 \mathrm{~V}\) to 0.1 V
Differential Reference Voltage
2.1V

Reference Midpoint Current . . . . . . . . . . . . . . \(\pm 4 \mathrm{~mA}\)
ENCODE to ENCODE Differential Voltage

Digital Output Current
20 mA
Operating Temperature Range
AD \(9002 \mathrm{AD} / \mathrm{BD} / \mathrm{AJ} / \mathrm{BJ}\). . . . . . . . . . \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)

AD9002SE/SD/TD/TE . . . . . . . . . . \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
Storage Temperature Range . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Junction Temperature \({ }^{3}\)
\(+175^{\circ} \mathrm{C}\)
Lead Soldering Temperature ( 10 sec )
\(+300^{\circ} \mathrm{C}\)

Electrical Characteristics \(\left(-V_{s}=-5.2 V\right.\); Differential Reference Votage \(=2.0 V\), ulless otherwise stater)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Parameter} & \multirow[b]{2}{*}{Temp} & \multirow[t]{2}{*}{\begin{tabular}{l}
Test \\
Level
\end{tabular}} & \multicolumn{3}{|c|}{AD9002AD/AJ} & \multicolumn{3}{|c|}{AD9002BD/BJ} & \multicolumn{3}{|c|}{AD9002SD/SE} & \multicolumn{3}{|c|}{AD9002TD/TE} & \multirow[b]{2}{*}{Units} \\
\hline & & & Min & Typ & Max & Min & Typ & Max & Min & Typ & Max & Min & Typ & Max & \\
\hline RESOLUTION & & & 8 & & & 8 & & & 8 & & & 8 & & & Bits \\
\hline \multicolumn{16}{|l|}{DCACCURACY} \\
\hline Differential Linearity & \(+25^{\circ} \mathrm{C}\) & , & & 0.6 & 0.75 & & 0.4 & 0.5 & & 0.6 & 0.75 & & 0.4 & 0.5 & LSB \\
\hline & Full & VI & & & 1.0 & & & 0.75 & & & 1.0 & & & 0.75 & LSB \\
\hline Integral Linearity & \(+25^{\circ} \mathrm{C}\) & I & & 0.6 & 1.0 & & 0.4 & 0.5 & & 0.6 & 1.0 & & 0.4 & 0.5 & LSB \\
\hline & Full & VI & & & 1.2 & & & 1.2 & & & 1.2 & & & 1.2 & LSB \\
\hline No Missing Codes & Full & VI & GUA & ANTE & & GUA & ANTE & & GUA & ANT & & GUA & ANT & & \\
\hline \multicolumn{16}{|l|}{INITIAL OFFSET ERROR} \\
\hline Top of Reference Ladder & \(+25^{\circ} \mathrm{C}\) & I & & & 14 & & 8 & 14 & & 8 & 14 & & 8 & 14 & mV \\
\hline & Full & VI & & & 17 & & & 17 & & & 17 & & & 17 & mV \\
\hline Bottom of Reference Ladder & \(+25^{\circ} \mathrm{C}\) & I & & & 10 & & & 10 & & 4 & 10 & & 4 & 10 & mV \\
\hline & Full & VI & & & 12 & & & 12 & & & 12 & & & 12 & mV \\
\hline Offset Drift Coefficient & Full & V & & 20 & & & 20 & & & 20 & & & 20 & & \(\mu \mathrm{V} /{ }^{\circ} \mathrm{C}\) \\
\hline \multicolumn{16}{|l|}{ANALOG INPUT} \\
\hline Input Bias Current \({ }^{4}\) & \(+25^{\circ} \mathrm{C}\) & I & & 60 & 100 & & 60 & 100 & & 60 & 100 & & 60 & 100 & \(\mu \mathrm{A}\) \\
\hline & Full & VI & & & 200 & & & 200 & & & 200 & & & 200 & \(\mu \mathrm{A}\) \\
\hline Input Resistance & \(+25^{\circ} \mathrm{C}\) & III & 100 & 200 & & 100 & 200 & & 100 & 200 & & 100 & 200 & & \(\mathrm{k} \Omega\) \\
\hline Input Capacitance & \(+25^{\circ} \mathrm{C}\) & III & & 17 & 22 & & 17 & 22 & & 17 & 22 & & 17 & 22 & pF \\
\hline Large Signal Bandwidth \({ }^{5}\) & \(+25^{\circ} \mathrm{C}\) & V & - & 160 & & & 160 & & & 160 & & & 160 & & MHz \\
\hline Input Slew Rate \({ }^{6}\) & \(+25^{\circ} \mathrm{C}\) & V & & 440 & & & 440 & & & 440 & & & 440 & & \(\mathrm{V} / \mathrm{\mu s}\) \\
\hline \multicolumn{16}{|l|}{REFERENCEINPUT} \\
\hline Reference Ladder Resistance & \(+25^{\circ} \mathrm{C}\) & VI & 64 & 80 & 110 & 64 & 80 & 110 & 64 & 80 & 110 & 64 & 80 & 110 & \(\Omega\) \\
\hline Ladder Temperature Coefficient & & V & & 0.25 & & & 0.25 & & & 0.25 & & & 0.25 & & \(\Omega /{ }^{\circ} \mathrm{C}\) \\
\hline Reference Input Bandwidth & \(+25^{\circ} \mathrm{C}\) & V & & 10 & & & 10 & & & 10 & & & 10 & & MHz \\
\hline \multicolumn{16}{|l|}{DYNAMIC PERFORMANCE} \\
\hline Conversion Rate & \(+25^{\circ} \mathrm{C}\) & I & 125 & 150 & & 125 & 150 & & 125 & 150 & & 125 & 150 & & MSPS \\
\hline Aperture Delay & \(+25^{\circ} \mathrm{C}\) & V & & 1.3 & & & 1.3 & & & 1.3 & & & 1.3 & & ns \\
\hline Aperture Uncertainty (Jitter) & \(+25^{\circ} \mathrm{C}\) & V & & 15 & & & 15 & & & 15 & & & 15 & & \\
\hline Output Delay (tpD) \({ }^{7,8}\) & \(+25^{\circ} \mathrm{C}\) & I & 2.5 & 3.7 & 5.5 & 2.5 & 3.7 & 5.5 & 2.5 & 3.7 & 5.5 & 2.5 & 3.7 & 5.5 & ns \\
\hline Transient Response \({ }^{9}\) & \(+25^{\circ} \mathrm{C}\) & V & & 6 & & & 6 & & & 6 & & & 6 & & ns \\
\hline Overvoltage Recovery Time \({ }^{10}\) & \(+25^{\circ} \mathrm{C}\) & V & & 6 & & & 6 & & & 6 & & & 6 & & ns \\
\hline Output Rise Time \({ }^{7}\) & \(+25^{\circ} \mathrm{C}\) & I & & & 3.0 & & & 3.0 & & & 3.0 & & & 3.0 & ns \\
\hline Output Fall Time \({ }^{7}\) & \(+25^{\circ} \mathrm{C}\) & I & & & 2.5 & & & 2.5 & & & 2.5 & & & 2.5 & ns \\
\hline Output Time Skew \({ }^{7,11}\) & \(+25^{\circ} \mathrm{C}\) & V & & 0.6 & & & 0.6 & & & 0.6 & & & 0.6 & & ns \\
\hline \multicolumn{16}{|l|}{ENCODEINPUT} \\
\hline Logic " 1 " Voltage" & Full & VI & -1.1 & & & -1.1 & & & -1.1 & & & -1.1 & & & V \\
\hline Logic " 0 " Voitage \({ }^{\text {] }}\) & Full & VI & & & -1.5 & & & -1.5 & & & -1.5 & & & -1.5 & V \\
\hline Logic " 1 " Current & Full & VI & & & 150 & & & 150 & & & 150 & & & 150 & \(\mu \mathrm{A}\) \\
\hline Logic "0"Current & Full & VI & & & 120 & & & 120 & & & 120 & & & 120 & \(\mu \mathrm{A}\) \\
\hline Input Capacitance & \(+25^{\circ} \mathrm{C}\) & V & & 3 & & & 3 & & & 3 & & & 3 & & pF \\
\hline Encode Pulse Width (Low) \({ }^{12}\) & \(+25^{\circ} \mathrm{C}\) & I & 1.5 & & & 1.5 & & & 1.5 & & & 1.5 & & & ns \\
\hline Encode Pulse Width (High) \({ }^{12}\) & \(+25^{\circ} \mathrm{C}\) & I & 1.5 & & & 1.5 & & & 1.5 & & & 1.5 & & & ns \\
\hline \multicolumn{16}{|l|}{} \\
\hline \multicolumn{16}{|l|}{ACLINEARITY \({ }^{13}\)} \\
\hline Effective Bits \({ }^{14}\) & \(+25^{\circ} \mathrm{C}\) & V & & 7.6 & & & 7.6 & & & 7.6 & & & 7.6 & & Bits \\
\hline \multicolumn{16}{|l|}{In-Band Harmonics} \\
\hline dc to 1.23 MHz & \(+25^{\circ} \mathrm{C}\) & , & 48 & 55 & & 48 & 55 & & 48 & 55 & & 48 & 55 & & dB \\
\hline dcto 9.3 MHz & \(+25^{\circ} \mathrm{C}\) & V & & 50 & & & 50 & & & 50 & & & 50 & & dB \\
\hline dc to 19.3 MHz & \(+25^{\circ} \mathrm{C}\) & V & & 44 & & & 44 & & & 44 & & & 44 & & dB \\
\hline Signal-to-Noise Ratio \({ }^{15}\) & \(+25^{\circ} \mathrm{C}\) & I & 46 & 47.6 & & 46 & 47.6 & & 46 & 47.6 & & 46 & 47.6 & & dB \\
\hline Two Tone Intermod Rejection \({ }^{16}\) & \(+25^{\circ} \mathrm{C}\) & V & & 60 & & & 60 & & & 60 & & & 60 & & dB \\
\hline \multicolumn{16}{|l|}{DIGITALOUTPUTS \({ }^{7}\)} \\
\hline Logic " 1 " Voltage & Full & VI & -1.1 & & & -1.1 & & & -1.1 & & & -1.1 & & & V \\
\hline Logic " 0 " V Voltage & Full & VI & & & -1.5 & & & -1.5 & & & -1.5 & & & -1.5 & V \\
\hline \multicolumn{16}{|l|}{POWER SUPPLY \({ }^{17}\)} \\
\hline Supply Current ( -5.2 V ) & \(+25^{\circ} \mathrm{C}\) & I & & 145 & 175 & & 145 & 175 & & 145 & 175 & & 145 & 175 & mA \\
\hline & Full & VI & & & 200 & & & 200 & & & 200 & & & 200 & mA \\
\hline Nominal Power Dissipation & \(+25^{\circ} \mathrm{C}\) & V & & 750 & & & 750 & & & 750 & & & 750 & & mW \\
\hline Reference Ladder Dissipation & \(+25^{\circ} \mathrm{C}\) & V & & 50 & & & 50 & & & 50 & & & 50 & & mW \\
\hline Power Supply Rejection Ratio \({ }^{18}\) & \(+25^{\circ} \mathrm{C}\) & I & & 0.8 & 1.5 & & 0.8 & 1.5 & & 0.8 & 1.5 & & 0.8 & 1.5 & \(\mathrm{mV} / \mathrm{V}\) \\
\hline
\end{tabular}

NOTES
\({ }^{1}\) Absolute maximum ratings are limiting values, to be applied individually, and beyond which the serviceability of the circuit may be impaired. Functional operability under any of these conditions is not necessarily implied. Exposure to absolute maximum rating conditions for extended periods of time may affect device reliability.
\({ }^{2}+V_{\text {REF }} \geq-V_{\text {REF }}\) under all circumstances:
\({ }^{3}\) Maximum junction temperature ( \(\mathrm{t}_{\mathrm{J}}\) max) should not exceed \(175^{\circ} \mathrm{C}\)
for ceramic packages, and \(150^{\circ} \mathrm{C}\) for plastic packages:
\(\mathrm{t}_{\mathrm{J}}=P \mathrm{PD}\left(\theta_{\mathrm{JA}}\right)+\mathrm{t}_{\mathrm{A}}\)
PD \(\left(\theta_{\mathrm{J}} \mathrm{C}\right)+\mathrm{t}_{\mathrm{C}}\)
where
\(\mathrm{PD}=\) power dissipation
\(\theta_{\mathrm{JA}}=\) thermal impedance from junction to ambient \(\left({ }^{\circ} \mathrm{C} / \mathrm{W}\right)\)
\(\theta_{\mathrm{JC}}=\) thermal impedance from junction to case \(\left({ }^{\circ} \mathrm{C} / \mathrm{W}\right)\)
\(\mathrm{t}_{\mathrm{A}}=\) ambient temperature \(\left({ }^{\circ} \mathrm{C}\right)\)
\(\mathrm{t}_{\mathrm{C}}=\) case temperature \(\left({ }^{\circ} \mathrm{C}\right)\)
typical thermal impedances are:
Ceramic DIP \(\theta_{\mathrm{JA}}=56^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=20^{\circ} \mathrm{C} / \mathrm{W}\)
Plastic DIP \(\theta_{\mathrm{JA}}=60^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=20^{\circ} \mathrm{C} / \mathrm{W}\)
Ceramic LCC \(\theta_{\mathrm{JA}}=69^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=23^{\circ} \mathrm{C} / \mathrm{W}\)
PLCC \(\theta_{\mathrm{JA}}=60^{\circ} \mathrm{C} / \mathrm{W}, \theta_{\mathrm{JC}}=19^{\circ} \mathrm{C} / \mathrm{W}\).
\({ }^{4}\) Measured with AIN \(=0 \mathrm{~V}\).
\({ }^{5}\) Measured by FFT analysis where fundamental is - 3 dB FS.
\({ }^{6}\) Input slew rate derived from rise time ( 10 to \(90 \%\) ) of full scale input.
\({ }^{7}\) Outputs terminated through \(100 \Omega\) to -2 V .
\({ }^{8}\) Measured from ENCODE in to data out for LSB only.
\({ }^{9}\) For full-scale step input, 8-bit accuracy is attained in specified time.
\({ }^{10}\) Recovers to 8 -bit accuracy in specified time after \(150 \%\) full-scale input overvoltage.
\({ }^{11}\) Output time skew includes high-to-low and low-to-high transitions as well as bit-to-bit time skew differences.
\({ }^{12}\) ENCODE signal rise/fall times should be less than 10ns for normal operation.
\({ }^{13}\) Measured at 125 MSPS encode rate.
\({ }^{14}\) Analog input frequency \(=1.23 \mathrm{MHz}\).
\({ }^{15}\) RMS signal to rms noise, with 1.23 MHz analog input signal.
\({ }^{16}\) Input signals 1V p-p @1.23MHz and 1V p-p @2.30MHz.
\({ }^{17}\) Supplies should remain stable within \(\pm 5 \%\) for normal operation.
\({ }^{18}\) Measured at \(-5.2 \mathrm{~V} \pm 5 \%\).
Specifications subject to change without notice.

Recommended Operating Conditions
\begin{tabular}{|l|l|l|l|}
\hline \multirow{2}{*}{ Parameter } & \multicolumn{3}{|c|}{ Input Voltage } \\
\cline { 2 - 4 } & Min & Nominal & Max \\
\hline\(-V_{\text {S }}\) & -5.46 & -5.20 & -4.94 \\
\(+V_{\text {REF }}\) & \(-V_{\text {REF }}\) & 0.0 V & +0.1 \\
\(-V_{\text {REF }}\) & -2.1 & -2.0 & \(+V_{\text {REF }}\) \\
Analog Input & \(-V_{\text {REF }}\) & & \(+V_{\text {REF }}\) \\
\hline
\end{tabular}

\section*{EXPLANATION OF TEST LEVELS}

Test Level I - \(100 \%\) production tested.
Test Level II - \(100 \%\) production tested at \(+25^{\circ} \mathrm{C}\), and sample tested at specified temperatures.
Test Level III
- Sample tested onily.

Test Level IV - Parameter is guaranteed by design and characterization testing.
Test Level V
- Parameter is a typical value only.

Test Level VI - All devices are \(100 \%\) production tested at \(+25^{\circ} \mathrm{C}\). \(100 \%\) production tested at temperature extremes for extended temperature devices; sample tested at temperature extremes for commercial/industrial devices.

\section*{ORDERING GUIDE}
\begin{tabular}{l|l|l|l}
\hline Model & Linearity & Temperature Range & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD9002AD & 0.75 LSB & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\mathrm{D}-28\) \\
AD9002BD & 0.50 LSB & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\mathrm{D}-28\) \\
AD9002AJ & 0.75 LSB & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\mathrm{J}-28\) \\
AD9002BJ & 0.50 LSB & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\mathrm{J}-28\) \\
AD9002SD & 0.75 LSB & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\mathrm{D}-28\) \\
AD9002SE & 0.75 LSB & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & E-28A \\
AD9002TD \(\mathrm{TD}^{2}\) & 0.50 LSB & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\mathrm{D}-28\) \\
\({\text { AD9002 } \mathrm{TE}^{2}}^{0.50 \mathrm{LSB}}\) & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & E-28A \\
\hline
\end{tabular}

NOTES
\({ }^{1} \mathrm{D}=\) Ceramic DIP; E = Leadless Ceramic Chip Carrier; \(\mathrm{J}=\) Ceramic Leaded
Chip Carrier. For outline information see Package Information section.
\({ }^{2}\) MIL-STD-883 versions.

\section*{FUNCTIONAL DESCRIPTION}


\section*{PIN DESIGNATIONS}


\section*{FEATURES}

100MSPS Encode Rate
Very Low Input Capacitance - 16pF
Low Power - 1W
TTL Compatible Outputs
MIL-STD-883 Compliant Versions Available

\section*{APPLICATIONS}

Radar Guidance
Digital Oscilloscopes/ATE Equipment
Laser/Radar Warning Receivers
Digital Radio
Electronic Warfare (ECM, ECCM, ESM)
Communication/Signal Intelligence

\section*{GENERAL DESCRIPTION}

The AD9012 is an 8-bit, ultrahigh speed, analog-to-digital converter. The AD9012 is fabricated in an advanced bipolar process, which allows operation at sampling rates up to 100 megasamples/second. Functionally, the AD9012 is comprised of 256 parallel comparator stages whose outputs are decoded to drive the TTL compatible output latches.

The exceptionally wide large signal analog input bandwidth of 160 MHz is due to an innovative comparator design and very close attention to device layout considerations. The wide input bandwidth of the AD9012 allows very accurate acquisition of high speed pulse inputs without an external track-and-hold. The comparator output decoding scheme minimizes false codes, which is critical to high speed linearity.

The AD9012 is available in two grades, one with 0.5LSB linearity and one with 0.75 LSB linearity. Both versions are offered in an industrial grade, \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\), packaged in a 28 -pin DIP

FUNCTIONAL BLOCK DIAGRAM

and a 28 -pin JLCC. The military temperature range devices, \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\), are available in ceramic DIP and LCC packages and are compliant to MIL-STD-883 Class B.
The AD9012 is available in versions compliant with MIL-STD883. Refer to the Analog Devices Military Products Databook or current AD9012/883B data sheet for detailed specifications.

ABSOLUTE MAXIMUM RATINGS \({ }^{\mathbf{1}}\)


Reference Midpoint Current . . . . . . . . . . . . . . \(\pm 4 \mathrm{~mA}\)
Digital Output Current
30 mA
Operating Temperature Range
\(\mathrm{AD} 9012 \mathrm{AQ} / \mathrm{BQ} / \mathrm{AJ} / \mathrm{BJ} . . . . . . . . . . \quad-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
AD9012SE/SQ/TE/TQ . . . . . . . . . . \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
Storage Temperature Range . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Junction Temperature \({ }^{3}\)
\(+175^{\circ} \mathrm{C}\)
Lead Soldering Temperature ( 10 sec )
\(+300^{\circ} \mathrm{C}\)

\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Parameter} & \multirow[b]{2}{*}{Temp} & \multirow[t]{2}{*}{\begin{tabular}{l}
Test \\
Level
\end{tabular}} & \multicolumn{3}{|c|}{AD9012AQ/AJ} & \multicolumn{3}{|c|}{AD9012BQ/BJ} & \multicolumn{3}{|c|}{AD9012SQ/SE} & \multicolumn{3}{|l|}{AD9012TQ/TE} & \multirow[b]{2}{*}{Units} \\
\hline & & & Min & Typ & Max & Min & Typ & Max & Min & Typ & Max & Min & Typ & Max & \\
\hline RESOLUTION & & & 8 & & & 8 & & & 8 & & & 8 & & & Bits \\
\hline \multicolumn{16}{|l|}{DCACCURACY} \\
\hline Differential Linearity & \(+25^{\circ} \mathrm{C}\) & I & & 0.6 & 0.75 & & 0.4 & 0.5 & & 0.6 & 0.75 & & 0.4 & 0.5 & LSB \\
\hline & Full & VI & & & 1.0 & & & 0.75 & & & 1.0 & & & 0.75 & LSB \\
\hline Integral Linearity & \(+25^{\circ} \mathrm{C}\) & I & & & 1.0 & & 0.4 & 0.5 & & 0.6 & 1.0 & & 0.4 & 0.5 & LSB \\
\hline & Full & VI & & & 1.2 & & & 1.2 & & & 1.2 & & & 1.2 & LSB \\
\hline No Missing Codes & Full & VI & GUA & ANTE & & & ANTE & & & RANTE & & & ANT & & \\
\hline \multicolumn{16}{|l|}{INITIAL OFFSET ERROR} \\
\hline Top of Reference Ladder & & I & & & 15 & & & 15 & & 7 & 15 & & 7 & & \\
\hline & Full & VI & & & 18 & & & 18 & & & 18 & & & \[
18
\] & mV \\
\hline Bottom of Reference Ladder & \(+25^{\circ} \mathrm{C}\) & I & & 6 & 10 & & & 10 & & & 10 & & & 10 & mV \\
\hline & Full & VI & & & 13 & & & 13 & & & 13 & & & 13 & mV \\
\hline Offset Drift Coefficient & Full & V & & 25 & & & 25 & & & 25 & & & 25 & & \(\mu \mathrm{V} /{ }^{\circ} \mathrm{C}\) \\
\hline \multicolumn{16}{|l|}{ANALOG INPUT} \\
\hline Input Bias Current \({ }^{4}\) & & & & & & & & & & & & & & & \(\mu \mathrm{A}\) \\
\hline & Full & VI & & & \[
200
\] & & & \[
200
\] & & & \[
200
\] & & & \[
200
\] & \(\mu \mathrm{A}\) \\
\hline Input Resistance & \(+25^{\circ} \mathrm{C}\) & 1 & 150 & 200 & & 150 & 200 & & 150 & 200 & & 150 & 200 & & \(\mathrm{k} \Omega\) \\
\hline Input Capacitance & \(+25^{\circ} \mathrm{C}\) & III & & & 18 & & & 18 & & & 18 & & & 18 & \\
\hline Large Signal Bandwidth \({ }^{5}\) & \(+25^{\circ} \mathrm{C}\) & V & & 160 & & & 160 & & & 160 & & & 160 & & \[
\mathrm{MHz}
\] \\
\hline Analog Input Slew Rate \({ }^{6}\) & \(+25^{\circ} \mathrm{C}\) & V & & 440 & & & 440 & & & 440 & & & 440 & & \(\mathrm{V} / \mu \mathrm{s}\) \\
\hline \multicolumn{16}{|l|}{REFERENCEINPUT} \\
\hline Reference Ladder Resistance & \(+25^{\circ} \mathrm{C}\) & VI & 64 & 80 & 110 & 64 & 80 & 110 & 64 & 80 & 110 & 64 & 80 & 110 & \\
\hline Ladder TemperatureCoefficient & & V & & 0.25 & & & 0.25 & & & 0.25 & : & & 0.25 & & \(\Omega /{ }^{\circ} \mathrm{C}\) \\
\hline Reference Input Bandwidth & \(+25^{\circ} \mathrm{C}\) & V & & 10 & & & 10 & & & 10 & & & 10 & & MHz \\
\hline \multicolumn{16}{|l|}{DYNAMICPERFORMANCE} \\
\hline Conversion Rate & \(+25^{\circ} \mathrm{C}\) & I & 75 & 100 & & 75 & 100 & & 75 & 100 & , & 75 & 100 & & MSPS \\
\hline Aperture Delay & \(+25^{\circ} \mathrm{C}\) & V & & 3.8 & & & 3.8 & & & 3.8 & & & 3.8 & & \\
\hline Aperture Uncertainty (Jitter) & \(+25^{\circ} \mathrm{C}\) & V & & 15 & & & 15 & & & 15 & & & 15 & & ps \\
\hline Output Delay (tpD) \({ }^{7,8}\) & \(+25^{\circ} \mathrm{C}\) & I & 4 & 4.9 & 11 & 4 & 4.9 & 11 & 4 & 4.9 & 11 & 4 & 4.9 & 11 & ns \\
\hline Transient Response \({ }^{9}\) & \(+25^{\circ} \mathrm{C}\) & V & & 8 & & & 8 & & & 8 & & & 8 & & ns \\
\hline Overvoltage Recovery Time \({ }^{10}\) & \(+25^{\circ} \mathrm{C}\) & V & & 8 & & & 8 & & & 8 & & & 8 & & ns \\
\hline Output Rise Time \({ }^{7}\) & \(+25^{\circ} \mathrm{C}\) & I & & 6.6 & 8.0 & & 6.6 & 8.0 & & 6.6 & 8.0 & & 6.6 & 8.0 & ns \\
\hline Output Fall Time \({ }^{7}\) & \(+25^{\circ} \mathrm{C}\) & I & & 3.3 & 4.3 & & 3.3 & 4.3 & & 3.3 & 4.3 & & 3.3 & 4.3 & ns \\
\hline Output Time Skew \({ }^{\text {7, }} 11\) & \(+25^{\circ} \mathrm{C}\) & V & & 3.0 & & & 3.0 & & & 3.0 & & & 3.0 & & ns \\
\hline \multicolumn{16}{|l|}{ENCODEINPUT} \\
\hline Logic " 1 " Voltage \({ }^{\text {7 }}\) & Full & VI & 2.0 & & & 2.0 & & & 2.0 & & & 2.0 & & & V \\
\hline Logic " 0 " Voltage \({ }^{7}\) & Full & VI & & & 0.8 & & & 0.8 & & & 0.8 & & & 0.8 & V \\
\hline Logic " 1 " Current & Full & VI & & & 250 & & & 250 & & & 250 & & & 250 & \(\mu \mathrm{A}\) \\
\hline Logic "0" Current & Full & VI & & & 400 & & & 400 & & & 400 & & & 400 & \(\mu \mathrm{A}\) \\
\hline Input Capacitance & \(+25^{\circ} \mathrm{C}\) & V & & 2.5 & & & 2.5 & & & 2.5 & & & 2.5 & & pF \\
\hline Encode Pulse Width (Low) \({ }^{12}\) & \(+25^{\circ} \mathrm{C}\) & I & 2.5 & & & 2.5 & & & 2.5 & & & 2.5 & & & ns \\
\hline Encode Pulse Width (High) \({ }^{12}\) & \(+25^{\circ} \mathrm{C}\) & I & 2.5 & & & 2.5 & * & & 2.5 & & & 2.5 & & & ns \\
\hline \multicolumn{16}{|l|}{OVERFLOW INHIBIT INPUT} \\
\hline \multicolumn{16}{|l|}{ACLINEARITY \({ }^{13}\)} \\
\hline Effective Bits \({ }^{14}\) & \(+25^{\circ} \mathrm{C}\) & V & & 7.5 & & . & 7.5 & & & 7.5 & & & 7.5 & & Bits \\
\hline \multicolumn{16}{|l|}{} \\
\hline dc to 1.23 MHz
dc to 9.3 MHz & \(+25^{\circ} \mathrm{C}\)
\(+25^{\circ} \mathrm{C}\) & I & 48 & & & & \[
\begin{aligned}
& 55 \\
& 50
\end{aligned}
\] & & & \[
\begin{aligned}
& 55 \\
& 50
\end{aligned}
\] & & & \[
\begin{aligned}
& 35 \\
& 50
\end{aligned}
\] & & dBc \\
\hline \begin{tabular}{l}
de to 9.3 MHz \\
dc to 19.3 MHz
\end{tabular} & \(+25^{\circ} \mathrm{C}\)
\(+25^{\circ} \mathrm{C}\) & v & & 50
44 & & & \[
\begin{aligned}
& 50 \\
& 44
\end{aligned}
\] & & & \[
\begin{aligned}
& 50 \\
& 44
\end{aligned}
\] & & & 44 & & \(\mathrm{dBc}^{\text {d }}\) \\
\hline Signal-to-Noise Ratio \({ }^{15}\) & \(+25^{\circ} \mathrm{C}\) & I & 46 & 47.6 & & 46 & 47.6 & & 46 & 47.6 & & 46 & 47.6 & & dBc \\
\hline Noise Power Ratio \({ }^{16}\) & \(+25^{\circ} \mathrm{C}\) & V & & 37 & & & 37 & & & 37 & & & 37 & & dBc \\
\hline \multicolumn{16}{|l|}{DIGITALOUTPUT} \\
\hline Logic " 1 " Voltage & Full & VI & 2.4 & & & 2.4 & & & 2.4 & & & 2.4 & & & V \\
\hline Logic " 0 " Voltage & Full & VI & & & 0.4 & & & 0.4 & & ; & 0.4 & & & 0.4 & V \\
\hline \multicolumn{16}{|l|}{POWER SUPPLY \({ }^{17}\)} \\
\hline Positive Supply Current ( +5.0 V ) & \(+25^{\circ} \mathrm{C}\) & I & & 33 & 45 & & 33 & 45 & & 33 & 45 & & 33 & 45 & mA \\
\hline & Full & VI & & & 48 & & & 48 & & & 48 & & & 48 & mA \\
\hline Supply Current (-5.2V) & \(+25^{\circ} \mathrm{C}\) & 1 & & 152 & 179 & & 152 & 179 & & 152 & 179 & & 152 & 179 & mA \\
\hline & Full & VI & & & 191 & & & 191 & & & 191 & & & 191 & mA \\
\hline Nominal Power Dissipation & \(+25^{\circ} \mathrm{C}\) & V & & 955 & & & 955 & & & 955 & & & 955 & & mW \\
\hline Reference Ladder Dissipation & \(+25^{\circ} \mathrm{C}\) & V & & \[
44
\] & & & 44 & & & 44 & & & 44 & & mW \\
\hline Power Supply Rejection Ratio \({ }^{18}\) & \(+25^{\circ} \mathrm{C}\) & I & & & 2.5 & & 0.85 & 2.5 & & 0.8 & 2.5 & & 0.8 & 2.5 & \(\mathrm{mV} / \mathrm{V}\) \\
\hline
\end{tabular}

NOTES
\({ }^{1}\) Absolute maximum ratings are limiting values, to be applied individually, and beyond which the serviceability of the circuit may be impaired. Functional operability under any of these conditions is not necessarily implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
\(2^{2}+V_{\text {REF }} \geq-V_{\text {REF }}\) under all circumstances.
\({ }^{3}\) Maximum junction temperature ( \(\mathrm{t}_{\mathrm{J}}\) max) should not exceed \(+175^{\circ} \mathrm{C}\)
for ceramic packages, and \(+150^{\circ} \mathrm{C}\) for plastic packages:
\(\mathrm{t}_{\mathbf{J}}=\mathbf{P D}\left(\theta_{\mathrm{JA}}\right)+\mathrm{t}_{\mathbf{A}}\) PD \(\left(\theta_{\mathrm{J}} \mathbf{C}\right)+\mathrm{t}_{\mathbf{C}}\)
where
PD = power dissipation
\(\theta_{\mathrm{JA}}=\) thermal impedance from junction to ambient \(\left({ }^{\circ} \mathrm{C} / \mathrm{W}\right)\)
\(\theta_{\mathrm{JC}}=\) thermal impedance from junction to case \(\left({ }^{\circ} \mathrm{C} / \mathrm{W}\right)\)
\(\mathrm{t}_{\mathbf{A}}=\) ambient temperature ( \({ }^{\circ} \mathrm{C}\) )
\(\mathrm{t}_{\mathrm{C}}=\) case temperature \(\left({ }^{\circ} \mathrm{C}\right)\)
typical thermal impedances are:
Ceramic DIP \(\theta_{\mathrm{JA}}=42^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=10^{\circ} \mathrm{C} / \mathrm{W}\) Ceramic LCC \(\theta_{\mathrm{JA}}=50^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=15^{\circ} \mathrm{C} / \mathrm{W}\) JLCC \(\theta_{\mathrm{JA}}=59^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=15^{\circ} \mathrm{C} / \mathrm{W}\).
\({ }^{4}\) Measured with Analog Input \(=0 \mathrm{~V}\).
\({ }^{5}\) Measured by FFT analysis where fundamental is -3 dBc .
\({ }^{6}\) Input slew rate derived from rise time ( \(10 \%\) to \(90 \%\) ) of full-scale step input.
\({ }^{7}\) Outputs terminated with two equivalent 'LS00 type loads. (See load circuit.)
\({ }^{8}\) Measured from ENCODE into data out for LSB only.
\({ }^{9}\) For full-scale step input, 8-bit accuracy is attained in specified time.
\({ }^{10}\) Recovers to 8 -bit accuracy in specified time, after \(150 \%\) full-scale input overvoltage.
\({ }^{11}\) Output time skew includes high-to-low and low-to-high transitions as well as bit-to-bit time skew differences.
\({ }^{12}\) ENCODE signal rise/fall times should be less than 30 ns for normal operation.
\({ }^{13}\) Measured at 75MSPS encode rate. Harmonic data based on worst case harmonics.
\({ }^{14}\) Analog input frequency \(=1.23 \mathrm{MHz}\).
\({ }^{15}\) RMS signal to rms noise, including harmonics with 1.23 MHz analog input signal.
\({ }^{16} \mathrm{NPR}\) measured @ 0.5 MHz . Noise Source is 250 mW (rms) from 0.5 MHz to 8 MHz .
\({ }^{17}\) Supplies should remain stable within \(\pm 5 \%\) for normal operation.
\({ }^{18}\) Measured at \(-5.2 \mathrm{~V} \pm 5 \%\) and \(+5.0 \mathrm{~V} \pm 5 \%\).
Specifications subject to change without notice.

Recommended Operating Conditions
\begin{tabular}{|l|l|l|l|}
\hline \multirow{2}{*}{ Parameter } & \multicolumn{3}{|c|}{ Input Voltage } \\
\cline { 2 - 4 } & Min & Nominal & Max \\
\hline\(-\mathrm{V}_{\mathrm{S}}\) & -5.46 & -5.20 & -4.94 \\
\(+\mathrm{V}_{\mathbf{S}}\) & +4.75 & 5.00 & +5.25 \\
\(+\mathrm{V}_{\text {REF }}\) & \(-\mathrm{V}_{\text {REF }}\) & 0.0 V & +0.1 \\
\(-\mathrm{V}_{\text {REF }}\) & -2.1 & -2.0 & \(+\mathrm{V}_{\text {REF }}\) \\
Analog Input & \(-\mathrm{V}_{\text {REF }}\) & & \(+\mathrm{V}_{\text {REF }}\) \\
\hline
\end{tabular}

\section*{LOAD CIRCUIT}

\begin{tabular}{|c|c|}
\hline \multicolumn{2}{|l|}{EXPLANATION OF TEST LEVELS} \\
\hline Test Level I & - 100\% production tested. \\
\hline Test Level II & - \(100 \%\) production tested at \(+25^{\circ} \mathrm{C}\), and sample tested at specified temperatures. \\
\hline Test Level III & - Sample tested only. \\
\hline Test Level IV & - Parameter is guaranteed by design and characterization testing. \\
\hline Test Level V & - Parameter is a typical value only. \\
\hline Test Level VI & - All devices are \(100 \%\) production tested at \(+25^{\circ} \mathrm{C}\). \(100 \%\) production tested at temperature extremes for extended temperature devices; sample tested at temperature extremes for commercial/industrial devices. \\
\hline
\end{tabular}

ORDERING GUIDE
\begin{tabular}{l|l|l|l}
\hline Device & Linearity & Temperature Range & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD9012AQ & 0.75 LSB & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\mathrm{Q}-28\) \\
AD9012BQ & 0.50 LSB & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\mathrm{Q}-28\) \\
AD9012AJ & 0.75 LSB & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\mathrm{J}-28\) \\
AD9012BJ & 0.50 LSB & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\mathrm{J}-28\) \\
AD9012SQ & 0.75 LSB & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\mathrm{Q}-28\) \\
AD9012SE & 0.75 LSB & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\mathrm{E}-28 \mathrm{~A}\) \\
AD9012TQ & 0.50 LSB & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\mathrm{Q}-28\) \\
AD9012TE & 0.50 LSB & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\mathrm{E}-28 \mathrm{~A}\) \\
\hline
\end{tabular}
* \(\mathrm{E}=\) Leadless Ceramic Chip Carrier; J = Ceramic Leaded Chip Carrier; \(\mathrm{Q}=\) Cerdip. For outline information see Package Information section.

\section*{FUNCTIONAL DESCRIPTION}
\begin{tabular}{|c|c|c|c|c|}
\hline \multicolumn{5}{|c|}{FUNCTIONAL DESCRIPTION} \\
\hline Pin \# & Name & \multicolumn{3}{|l|}{Description} \\
\hline 1 & DIGITAL \(+\mathrm{V}_{\text {S }}\) & \multicolumn{3}{|l|}{One of three positive digital supply pins (nominally +5.0 V ).} \\
\hline 2 & OVERFLOW INH & OVERFLOW & HIBIT controls the data output coding for & voltage inputs (AIN \(\geqslant+\mathrm{V}_{\mathrm{F}}\) \\
\hline & & ANALOG INPUT & \begin{tabular}{l}
OVERFLOW ENABLED (FLOATING \\

\end{tabular} & OVERFLOW INHIBITED (GND) OF \(\mathrm{D}_{1} \mathrm{D}_{2} \mathrm{D}_{3} \mathrm{D}_{4} \mathrm{D}_{5} \mathrm{D}_{6} \mathrm{D}_{7} \mathrm{D}_{8}\) \\
\hline & & \(\mathrm{V}_{\text {IN }} \geqslant+\mathrm{V}_{\text {REF }}\)
\(\mathrm{V}_{\text {IN }}<+\mathrm{V}_{\text {REF }}\) & \(\begin{array}{ccccccccc}1 & 0 & 0 & 0 & 0 & 0 & 0 & 0 & 0 \\ 0 & \mathrm{X} & \mathrm{X} & \mathrm{X} & \mathrm{X} & \mathrm{X} & \mathrm{X} & \mathrm{X} & \mathrm{X}\end{array}\) & \(\begin{array}{ccccccccc}0 & 1 & 1 & 1 & 1 & 1 & 1 & 1 & 1 \\ 0 & \mathbf{X} & \mathrm{X} & \mathrm{X} & \mathrm{X} & \mathrm{X} & \mathrm{X} & \mathrm{X} & \mathrm{X}\end{array}\) \\
\hline 3 & HYSTERESIS & \multicolumn{3}{|l|}{The Hysteresis control voltage varies the comparator hysteresis from 0 mV to 10 mV , for a change from -5.2 V to -2.2 V at the Hysteresis control pin.} \\
\hline 4 & \(+\mathrm{V}_{\text {REF }}\) & \multicolumn{3}{|l|}{The most positive reference voltage for the internal resistor ladder.} \\
\hline 5 & ANALOG INPUT & \multicolumn{3}{|l|}{One of two analog input pins. Both analog input pins should be connected together.} \\
\hline 6 & ANALOGGROUND & \multicolumn{3}{|l|}{One of two analog ground pins. Both analog ground pins should be connected together.} \\
\hline 7 & ENCODE & \multicolumn{3}{|l|}{TTL level encode command input. ENCODE is rising edge sensitive.} \\
\hline 8 & DIGITAL \(+\mathrm{V}_{\text {S }}\) & \multicolumn{3}{|l|}{One of three positive digital supply pins (nominally +5.0 V ).} \\
\hline 9 & ANALOG GROUND & \multicolumn{3}{|l|}{One of two analog ground pins. Both analog ground pins should be connected together.} \\
\hline 10 & ANALOG INPUT & \multicolumn{3}{|l|}{One of two analog input pins. Both analog inputs should be connected together.} \\
\hline 11 & - \(\mathrm{V}_{\text {REF }}\) & \multicolumn{3}{|l|}{The most negative reference voltage for the internal resistor ladder.} \\
\hline 12 & \(\mathrm{REF}_{\text {MID }}\) & \multicolumn{3}{|l|}{The midpoint tap on the internal resistor ladder.} \\
\hline 13 & DIGITAL \(+\mathrm{V}_{\text {S }}\) & \multicolumn{3}{|l|}{One of three positive digital supply pins (nominally +5.0 V )} \\
\hline 14 & DIGITAL \(-\mathrm{V}_{\text {S }}\) & \multicolumn{3}{|l|}{One of two negative digital supply pins (nominally -5.2 V ). Both digital supply pins should be connected together.} \\
\hline 15 & \(\mathrm{D}_{1}\) (LSB) & \multicolumn{3}{|l|}{Digital data output. \(\mathrm{D}_{1}\) (LSB) is the least significant bit of the digital output word.} \\
\hline 16-19 & \(\mathrm{D}_{2}-\mathrm{D}_{5}\) & \multicolumn{3}{|l|}{Digital data output.} \\
\hline 20 & DIGITALGROUND & \multicolumn{3}{|l|}{One of two digital ground pins. Both digital grounds pins should be connected together.} \\
\hline 21,22 & ANALOG - \(\mathrm{V}_{\text {S }}\) & \multicolumn{3}{|l|}{One of two negative analog supply pins (nominally -5.2 V ). Both analog supply pins should be connected together.} \\
\hline 23 & DIGITALGROUND & \multicolumn{3}{|l|}{One of two digital ground pins. Both digital ground pins should be connected together.} \\
\hline 24,25 & \(\mathrm{D}_{6}, \mathrm{D}_{7}\) & \multicolumn{3}{|l|}{Digital data output.} \\
\hline 26 & \(\mathrm{D}_{8}\) (MSB) & \multicolumn{3}{|l|}{Digital data output \(\mathrm{D}_{8}\) (MSB) is the most significant bit of the digital output word.} \\
\hline 27 & OVERFLOW & \multicolumn{3}{|l|}{Overflow data output. Logic HIGH indicates an input overvoltage ( \(\mathrm{V}_{\text {IN }}>+\mathrm{V}_{\text {REF }}\) ), if OVERFLOW INHIBIT is enabled (overflow enabled, floating). See OVERFLOW INHIBIT.} \\
\hline 28 & DIGITAL \(-\mathrm{V}_{\text {S }}\) & \multicolumn{3}{|l|}{One of two negative digital supply pins (nominally -5.2 V ). Both digital supply pins should be connected together.} \\
\hline
\end{tabular}

\section*{PIN DESIGNATIONS}


FEATURES
Monolithic 10-Bit/60 MSPS Converter
TTL Outputs
Bipolar ( \(\pm 1.75\) V) Analog Input
56 dB SNR @ 2.3 MHz Input
Low ( 45 pF) Input Capacitance
MIL-STD-883 Compliant Versions Available
APPLICATIONS
Digital Oscilloscopes
Medical Imaging
Professional Video
Radar Warning/Guidance Systems
Infrared Systems

\section*{GENERAL DESCRIPTION}

The AD9020 A/D converter is a 10 -bit monolithic converter capable of word rates of 60 MSPS and above. Innovative architecture using 512 input comparators instead of the traditional 1024 required by other flash converters reduces input capacitance and improves linearity.
Encode and outputs are TTL-compatible, making the AD9020 an ideal candidate for use in low power systems. An overflow bit is provided to indicate analog input signals greater than \(+\mathrm{V}_{\text {SENSE }}\).
Voltage sense lines are provided to insure accurate driving of the \(\pm \mathrm{V}_{\text {REF }}\) voltages applied to the units. Quarter-point taps on the resistor ladder help optimize the integral linearity of the unit.
Either 68 -pin ceramic leaded (gull wing) packages or ceramic LCCs are available and are specifically designed for low thermal impedances. Two performance grades for temperatures of both 0 to \(+70^{\circ} \mathrm{C}\) and \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) ranges are offered to allow the user to select the linearity best suited for each application. Dynamic performance is fully characterized and production tested at \(+25^{\circ} \mathrm{C}\). MIL-STD-883 units are available.
The AD9020 A/D Converter is available in versions compliant with MIL-STD-883. Refer to the Analog Devices Military Products Databook or current AD9020/883B data sheet for detailed specifications.

FUNCTIONAL BLOCK DIAGRAM


This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.
\begin{tabular}{|c|c|}
\hline + \(\mathrm{V}_{\text {s }}\) & 6 V \\
\hline - \(\mathrm{V}_{\text {s }}\) & -6 V \\
\hline ANALOG IN & -2 V to +2 V \\
\hline \(+\mathrm{V}_{\text {REF }},-\mathrm{V}_{\text {REF }}, 3 / 4_{\text {REF }}, 1 / 2_{\text {REF }}, 1 / 4_{\text {REF }}\) & -2 V to +2 V \\
\hline \(+\mathrm{V}_{\text {REF }}\) to \(-\mathrm{V}_{\text {REF }}\) & 4.0 \\
\hline DIGITAL INPUT & -0.5 V to \(+\mathrm{V}_{\mathrm{s}}\) \\
\hline
\end{tabular}
\(3 / 4_{\text {REF }}, 1 / 2_{\text {REF }}, 1 / 4_{\text {REF }}\) Current \(\ldots . . . . . . . . . . . . . .\).
Digital Output Current . . . . . . . . . . . . . . . . . . . . . . 20 mA
Operating Temperature
AD9020JE/KE/JZ/KZ . . . . . . . . . . . . . . . . . . 0 to \(+70^{\circ} \mathrm{C}\)
Storage Temperature . . . . . . . . . . . . . . . . . \(65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Maximum Junction Temperature \({ }^{2}\). . . . . . . . . . . . . . \(+175^{\circ} \mathrm{C}\)
Lead Soldering Temp ( 10 sec )
\(+300^{\circ} \mathrm{C}\)

ELECTRICAL CHARACTERISTICS \(\left( \pm V_{S}= \pm 5 \mathrm{~V} ; \pm \mathrm{V}_{\text {SENSE }}= \pm 1.75 \mathrm{~V} \text {; ENCODE }=40 \mathrm{MSPS} \text { unless otherwise noted }\right)^{3}\)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Parameter (Conditions)} & \multirow[b]{2}{*}{Temp} & \multirow[t]{2}{*}{Test Level} & \multicolumn{3}{|c|}{AD9020JE/JZ} & \multicolumn{3}{|c|}{AD9020KE/KZ} & \multirow[b]{2}{*}{Units} \\
\hline & & & Min & Typ & Max & Min & Typ & Max & \\
\hline RESOLUTION & & & 10 & & & 10 & & & Bits \\
\hline \multicolumn{10}{|l|}{DC ACCURACY \({ }^{3}\)} \\
\hline Differential Nonlinearity & \(+25^{\circ} \mathrm{C}\) & I & & 1.0 & 1.25 & & 0.75 & 1.0 & LSB \\
\hline & Full & VI & & & 1.5 & & & 1.25 & LSB \\
\hline Integral Nonlinearity & \(+25^{\circ} \mathrm{C}\) & I & & 1.25 & 2.0 & & 1.0 & 1.5 & LSB \\
\hline & Full & VI & & & 2.5 & & & 2.0 & LSB \\
\hline No Missing Codes & Full & VI & & & & & arant & & \\
\hline \multicolumn{10}{|l|}{ANALOG INPUT} \\
\hline Input Bias Current \({ }^{4}\) & \(+25^{\circ} \mathrm{C}\) & I & & 0.4 & 1.0 & & 0.4 & 1.0 & mA \\
\hline & Full & VI & & & 2.0 & & & 2.0 & mA \\
\hline Input Resistance & \(+25^{\circ} \mathrm{C}\) & I & 2.0 & 7.0 & & 2.0 & 7.0 & & \(\mathrm{k} \Omega\) \\
\hline Input Capacitance \({ }^{4}\) & \(+25^{\circ} \mathrm{C}\) & V & & 45 & & & 45 & & pF \\
\hline Analog Bandwidth & \(+25^{\circ} \mathrm{C}\) & V & & 175 & & & 175 & & MHz \\
\hline \multicolumn{10}{|l|}{REFERENCE INPUT} \\
\hline Reference Ladder Resistance & \(+25^{\circ} \mathrm{C}\) & I & 22 & 37 & 56 & 22 & 37 & 56 & \(\Omega\) \\
\hline & Full & VI & 14 & & 66 & 14 & & 66 & \(\Omega\) \\
\hline Ladder Tempco & Full & V & & 0.1 & & & 0.1 & & \(\Omega /{ }^{\circ} \mathrm{C}\) \\
\hline \multicolumn{10}{|l|}{Reference Ladder Offset} \\
\hline Top of Ladder & \(+25^{\circ} \mathrm{C}\) & I & & 45 & 90 & & 45 & 90 & mV \\
\hline & Full & VI & & & 90 & & & 90 & mV \\
\hline Bottom of Ladder & \(+25^{\circ} \mathrm{C}\) & I & & 45 & 90 & & 45 & 90 & mV \\
\hline & Full & VI & & & 90 & & & 90 & mV \\
\hline Offset Drift Coefficient & Full & V & & 50 & & & 50 & & \(\mu \mathrm{V} /{ }^{\circ} \mathrm{C}\) \\
\hline \multicolumn{10}{|l|}{SWITCHING PERFORMANCE} \\
\hline Conversion Rate & \(+25^{\circ} \mathrm{C}\) & I & 60 & & & 60 & & & MSPS \\
\hline Aperture Delay ( \(\mathrm{t}_{\mathrm{A}}\) ) & \(+25^{\circ} \mathrm{C}\) & V & & 1 & & & 1 & & \\
\hline Aperture Uncertainty (Jitter) & \(+25^{\circ} \mathrm{C}\) & V & & 5 & & & 5 & & \(\mathrm{ps}, \mathrm{rms}\) \\
\hline Output Delay ( \(\left.\mathrm{t}_{\text {OD }}\right)^{5}\) & \(+25^{\circ} \mathrm{C}\) & I & 6 & 10 & 13 & 6 & 10 & 13 & \\
\hline Output Time Skew \({ }^{5}\) & \(+25^{\circ} \mathrm{C}\) & I & & 3 & 5 & & 3 & 5 & ns \\
\hline \multicolumn{10}{|l|}{DYNAMIC PERFORMANCE} \\
\hline Transient Response & \(+25^{\circ} \mathrm{C}\) & V & & 10 & & & 10 & & ns \\
\hline Overvoltage Recovery Time & \(+25^{\circ} \mathrm{C}\) & V & & 10 & & & 10 & & ns \\
\hline \multicolumn{10}{|l|}{Effective Number of Bits (ENOB)} \\
\hline \[
\mathrm{f}_{\mathrm{IN}}=2.3 \mathrm{MHz}
\] & \(+25^{\circ} \mathrm{C}\) & I & 8.6 & 9.0 & & 8.6 & 9.0 & & Bits \\
\hline \(\mathrm{f}_{\mathrm{IN}}=10.3 \mathrm{MHz}\) & \(+25^{\circ} \mathrm{C}\) & IV & 8.0 & 8.4 & & 8.0 & 8.4 & & Bits \\
\hline & . \(+25^{\circ} \mathrm{C}\) & IV & 7.5 & 8.0 & & 7.5 & 8.0 & & Bits \\
\hline \multicolumn{10}{|l|}{Signal-to-Noise Ratio \({ }^{6}\)} \\
\hline \(\mathrm{f}_{\text {IN }}=2.3 \mathrm{MHz}\) & \(+25^{\circ} \mathrm{C}\) & I & 54 & 56 & & 54 & 56 & & dB \\
\hline \(\mathrm{f}_{\mathrm{IN}}=10.3 \mathrm{MHz}\) & \(+25^{\circ} \mathrm{C}\) & I & 50 & 53 & & 50 & 53 & & dB \\
\hline \(\mathrm{f}_{\mathrm{IN}}=15.3 \mathrm{MHz}\) & \(+25^{\circ} \mathrm{C}\) & I & 47 & 50 & & 47 & 50 & & dB \\
\hline \multicolumn{10}{|l|}{Signal-to-Noise Ratio \({ }^{6}\) (Without Harmonics)} \\
\hline \(\mathrm{f}_{\mathrm{IN}}=2.3 \mathrm{MHz}\) & \(+25^{\circ} \mathrm{C}\) & I & 54 & 56 & & 54 & 56 & & dB \\
\hline \(\mathrm{f}_{\mathrm{IN}}=10.3 \mathrm{MHz}\) & \(+25^{\circ} \mathrm{C}\) & 1 & 51 & 54 & & 51 & 54 & & dB \\
\hline \(\mathrm{f}_{\mathrm{IN}}=15.3 \mathrm{MHz}\) & \(+25^{\circ} \mathrm{C}\) & I & 48 & 52 & & 48 & 52 & & dB \\
\hline
\end{tabular}

AD9020
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Parameter (Conditions)} & \multirow[b]{2}{*}{Temp} & \multirow[t]{2}{*}{Test Level} & \multicolumn{3}{|c|}{AD9020JE/JZ} & \multicolumn{3}{|c|}{AD9020KE/KZ} & \multirow[b]{2}{*}{Units} \\
\hline & & & Min & Typ & Max & Min & Typ & Max & \\
\hline \multicolumn{10}{|l|}{DYNAMIC PERFORMANCE (CONTINUED)} \\
\hline \multicolumn{10}{|l|}{Harmonic Distortion} \\
\hline \(\mathrm{f}_{\mathrm{IN}}=2.3 \mathrm{MHz}\) & \(+25^{\circ} \mathrm{C}\) & I & 61 & 67 & & 61 & 67 & & dBc \\
\hline \(\mathrm{f}_{\text {IN }}=10.3 \mathrm{MHz}\) & \(+25^{\circ} \mathrm{C}\) & I & 55 & 59 & & 55 & 59 & & dBc \\
\hline \(\mathrm{f}_{\text {IN }}=15.3 \mathrm{MHz}\) & \(+25^{\circ} \mathrm{C}\) & I & 49 & 53 & & 49 & 53 & & dBc \\
\hline \multicolumn{10}{|l|}{Two-Tone Intermodulation} \\
\hline Distortion Rejection \({ }^{7}\) & \(+25^{\circ} \mathrm{C}\) & V & & 70 & & & 70 & & dBc \\
\hline Differential Phase & \(+25^{\circ} \mathrm{C}\) & V & & 0.5 & & & 0.5 & & Degree \\
\hline Differential Gain & \(+25^{\circ} \mathrm{C}\) & V & & 1 & & & 1 & & \% \\
\hline \multicolumn{10}{|l|}{ENCODE INPUT} \\
\hline Logic " 1 " Voltage & Full & VI & 2.0 & & & 2.0 & & & V \\
\hline Logic "0" Voltage & Full & VI & & & 0.8 & & & 0.8 & V \\
\hline Logic " 1 " Current & Full & VI & & & 20 & & & 20 & \(\mu \mathrm{A}\) \\
\hline Logic "0" Current & Full & VI & & & 800 & & & 800 & \(\mu \mathrm{A}\) \\
\hline Input Capacitance & \(+25^{\circ} \mathrm{C}\) & V & & 5 & & & 5 & & pF \\
\hline Pulse Width (High) & \(+25^{\circ} \mathrm{C}\) & I & 6 & & & 6 & & & ns \\
\hline Pulse Width (Low) & \(+25^{\circ} \mathrm{C}\) & I & 6 & & & 6 & & & ns \\
\hline \multicolumn{10}{|l|}{DIGITAL OUTPUTS} \\
\hline Logic " 1 " Voltage ( \(\mathrm{I}_{\mathrm{OH}}=2 \mathrm{~mA}\) ) & Full & VI & 2.4 & & & 2.4 & & & V \\
\hline Logic " 0 " Voltage ( \(\mathrm{I}_{\mathrm{OL}}=10 \mathrm{~mA}\) ) & Full & VI & & & 0.4 & & & & V \\
\hline \multicolumn{10}{|l|}{POWER SUPPLY} \\
\hline + \(\mathrm{V}_{\text {S }}\) Supply Current & \(+25^{\circ} \mathrm{C}\) & I & & 440 & 530 & & 440 & 530 & mA \\
\hline & Full & VI & & & 542 & & & 542 & mA \\
\hline - \(\mathrm{V}_{\text {S }}\) Supply Current & \(+25^{\circ} \mathrm{C}\) & I & & 140 & 170 & & 140 & 170 & mA \\
\hline & Full & VI & & & 177 & & & 177 & mA \\
\hline Power Dissipation & \(+25^{\circ} \mathrm{C}\) & I & & 2.8 & 3.3 & & 2.8 & 3.3 & W \\
\hline & Full & VI & & & 3.4 & & & 3.4 & W \\
\hline Power Supply Rejection Ratio (PSRR) \({ }^{8}\) & Full & VI & & 6 & 10 & & 6 & 10 & \(\mathrm{mV} / \mathrm{V}\) \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Absolute maximum ratings are limiting values to be applied individually, and beyond which the serviceability of the circuit may be impaired. Functional operability is not necessarily implied. Exposure to absolute maximum rating conditions for an extended period of time may affect device reliability.
\({ }^{2}\) Typical thermal impedances (part soldered onto board): 68-pin leaded ceramic chip carrier: \(\theta_{\mathrm{JC}}=1{ }^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JA}}=17^{\circ} \mathrm{C} / \mathrm{W}\) (no air flow); \(\theta_{\mathrm{JA}}=15^{\circ} \mathrm{C} / \mathrm{W}\) (air flow \(=500 \mathrm{LFM}\) ). 68-pin ceramic LCC: \(\theta_{\mathrm{JC}}=2.6^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JA}}=15^{\circ} \mathrm{C} / \mathrm{W}\) (no air flow); \(\theta_{\mathrm{JA}}=13^{\circ} \mathrm{C} / \mathrm{W}\) (air flow \(=500 \mathrm{LFM}\) ).
\({ }^{3} 3 / 4_{\text {REF }}, 1 / 2_{\text {REF }}\), and \(1 / 4_{\text {REF }}\) reference ladder taps are driven from dc sources at \(+0.875 \mathrm{~V}, 0 \mathrm{~V}\), and -0.875 V , respectively. Accuracy of the overflow comparator is not tested and not included in linearity specifications.
\({ }^{4}\) Measured with ANALOG IN \(=+\mathrm{V}_{\text {SENSE }}\).
\({ }^{5}\) Output delay measured as worst-case time from \(50 \%\) point of the rising edge of ENCODE to \(50 \%\) point of the slowest rising or falling edge of \(D_{0}-D_{9}\). Output skew measured as worst-case difference in output delay among \(D_{0}-D_{9}\).
\({ }^{6}\) RMS signal to rms noise with analog input signal 1 dB below full scale at specified frequency.
\({ }^{7}\) Intermodulation measured with analog input frequencies of 2.3 MHz and 3.0 MHz at 7 dB below full scale.
\({ }^{8}\) Measured as the ratio of the worst-case change in transition voltage of a single comparator for a \(5 \%\) change in \(+V_{S}\) or \(-V_{s}\). Specifications subject to change without notice.

\section*{EXPLANATION OF TEST LEVELS \\ Test Level}

I - \(100 \%\) production tested.
II - \(100 \%\) production tested at \(+25^{\circ} \mathrm{C}\), and sample tested at specified temperatures.
III - Sample tested only.
IV - Parameter is guaranteed by design and characterization testing.
V - Parameter is a typical value only.
VI - All devices are \(100 \%\) production tested at \(+25^{\circ} \mathrm{C}\). \(100 \%\) production tested at temperature extremes for extended temperature devices; sample tested at temperature extremes for commercial/industrial devices.

ORDERING GUIDE
\begin{tabular}{l|l|l|l}
\hline & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & Description & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD9020JZ & 0 to \(+70^{\circ} \mathrm{C}\) & 68 -Pin Leaded Ceramic & Z-68 \\
AD9020JE & 0 to \(+70^{\circ} \mathrm{C}\) & 68 -Pin Ceramic LCC & E-68A \\
AD9020KZ & 0 to \(+70^{\circ} \mathrm{C}\) & 68 -Pin Leaded Ceramic & Z-68 \\
AD9020KE & 0 to \(+70^{\circ} \mathrm{C}\) & 68 -Pin Ceramic LCC & E-68A \\
AD9020SZ/883 & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 68 -Pin Leaded Ceramic & Z-68 \\
AD9020SE/883 & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 68 -Pin Ceramic LCC & E-68A \\
AD9020TZ/883 & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 68 -Pin Leaded Ceramic & Z-68 \\
AD9020TE/883 & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 68 -Pin Ceramic LCC & E-68A \\
AD9020/PCB & 0 to \(+70^{\circ} \mathrm{C}\) & Evaluation Board & \\
\hline
\end{tabular}
*E = Ceramic Leadless Chip Carrier; Z = Ceramic Leaded Chip Carrier. For outline information see Package Information section.


12-Bit 20 MSPS

FEATURES
Monolithic
12-Bit 20 MSPS A/D Converter
Low Power Dissipation: 1.3 Watts
On-Chip T/H and Reference
High-Spurii Free Dynamic Range
TTL Logic
APPLICATIONS
Radar Receivers
Digital Communications
Digital Instrumentation
Electro-Optics

FUNCTIONAL BLOCK DIAGRAM


\section*{PRODUCT DESCRIPTION}

The AD9022 is a high speed, high performance, monolithic 12bit analog-to-digital converter. All necessary functions, including track-and-hold ( \(\mathrm{T} / \mathrm{H}\) ) and reference, are included on chip to provide a complete conversion solution. It is a companion unit to the AD9023; the primary difference between the two is that all logic for the AD9022 is TTL compatible, while the AD9023 utilizes ECL logic for digital inputs and outputs. Pinouts for the two parts are nearly identical.
Operating from +5 V and -5.2 V supplies, the AD9022 provides excellent dynamic performance. Sampling at 20 Msps with \(\mathrm{A}_{\mathrm{IN}}=1 \mathrm{MHz}\), the spurious free dynamic range (SFDR) is typically 80 dB ; with \(\mathrm{A}_{\mathrm{IN}}=9.6 \mathrm{MHz}\), SFDR is 74 dB . SNR is typically 65 dB .
The on-board T/H has a 100 MHz bandwidth and, more importantly, is designed to provide excellent dynamic performance for analog input frequencies above Nyquist. This feature is necessary in many under-sampling signal processing applications, such as in direct IF to digital conversion.
To maintain dynamic performance at higher IFs, monolithic RF track-and-holds (such as the AD9100 and AD9101 Samplifier \({ }^{\mathrm{TM}}\) ) can be used with the AD9022 to process signals up to and beyond 70 MHz .

Samplifier is a trademark of Analog Devices, Inc.

With DNL typically less than 0.5 LSB and 20 ns transient response settling time, the AD9022 provides excellent results when low-frequency analog inputs must be oversampled (such as CCD digitization). The full scale analog input is \(\pm 1 \mathrm{~V}\) with a \(300 \Omega\) input impedance. The analog input can be driven directly from the signal source, or can be buffered by the AD96xx series of Low noise, low distortion buffer amplifiers.
All timing is internal to the AD9022; the clock signal initiates the conversion cycle. For best results, the encode command should contain as little jitter as possible. High speed layout practices must be followed to ensure optimum \(\mathrm{A} / \mathrm{D}\) performance.
The AD9022 is built on a trench isolated bipolar process and utilizes an innovative multipass architecture (see the block diagram). The unit is packaged in 28-pin ceramic DIPs and gullwing surface mount packages. The AD9022 is specified to operate over the industrial \(\left(-25^{\circ} \mathrm{C}\right.\) to \(\left.+85^{\circ} \mathrm{C}\right)\) and military \(\left(-55^{\circ} \mathrm{C}\right.\) to \(\left.+125^{\circ} \mathrm{C}\right)\) temperature ranges.



This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

AD9022-SPECIFICATIONS


NOTES
\({ }^{1}\) AD9022 load is a single LS latch.
\({ }^{2}\) RMS signal-to-rms noise with analog input signal 1 dB below full scale at specified frequency.
\({ }^{3}\) Intermodulation measured with analog input frequencies of 9.3 MHz and 9.6 MHz at 7 dB below full scale.
\({ }^{4}\) PSRR is sensitivity of offset error to power supply variations within the \(5 \%\) limits shown.
Specifications subject to change without notice.


AD9022 Timing Diagram

\section*{ABSOLUTE MAXIMUM RATINGS \({ }^{1}\)}


ORDERING GUIDE
\begin{tabular}{l|l|l|l}
\hline Model & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Package \\
Description
\end{tabular} & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline \(\mathrm{AD} 9022 \mathrm{AQ} / \mathrm{BQ}\) & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 28-Pin Ceramic DIP & \(\mathrm{Q}-28\) \\
\(\mathrm{AD} 9022 \mathrm{AZ} / \mathrm{BZ}\) & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \begin{tabular}{l} 
28-Pin Ceramic \\
Leaded Chip Carrier
\end{tabular} & \(\mathrm{Z}-28\) \\
AD 9022 SQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \begin{tabular}{l} 
28-Pin Ceramic DIP \\
2D9022SZ
\end{tabular} & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) \\
28-Pin Ceramic \\
Leaded Chip Carrier
\end{tabular} Z Z-28
*For outline information see Package Information section.

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\section*{EXPLANATION OF TEST LEVELS}

\section*{Test Level}

I - \(100 \%\) production tested.
II - \(100 \%\) production tested at \(+25^{\circ} \mathrm{C}\), and sample tested at specified temperatures. AC testing done on sample basis.
III - Sample tested only.
IV - Parameter is guaranteed by design and characterization testing.
V - Parameter is a typical value only.
VI - All devices are \(100 \%\) production tested at \(+25^{\circ} \mathrm{C} .100 \%\) production tested at temperature extremes for extended temperature devices; guaranteed by design and characterization testing for industrial devices.

DIE LAYOUT AND MECHANICAL INFORMATION
Die Dimensions . . . . . . . . . . . . . . . . \(205 \times 228 \times 21( \pm 1)\) mils Pad Dimensions . . . . . . . . . . . . . . . . . . . . . . . . . . . \(4 \times 4\) mils Metalization . . . . . . . . . . . . . . . . . . . . . . . . . . . . . Aluminum
Backing . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . None
Substrate Potential . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . - V \(_{\text {S }}\)
Transistor Count . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 4,080
Passivation . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . Oxynitride
Die Attach
Bond Wire

PIN DESCRIPTIONS
\begin{tabular}{|c|c|c|}
\hline Pin No. & Name & Function \\
\hline 1-3 & D3-D1 & Digital output bits of ADC; TTL/CMOS compatible. \\
\hline 4 & D0 (LSB) & Least significant bit of ADC output; TTL/CMOS compatible. \\
\hline 5 & NC & No Connection Internally \\
\hline 6 & \(+\mathrm{V}_{\text {S }}\) & +5 V Power Supply \\
\hline 7 & GND & Ground \\
\hline 8 & ENCODE & Encode clock input to ADC. Internal \(\mathrm{T} / \mathrm{H}\) is placed in hold mode (ADC is encoding) on rising edge of encode signal. \\
\hline 9 & GND & Ground \\
\hline 10 & \(+\mathrm{V}_{\text {S }}\) & +5 V Power Supply \\
\hline 11 & GND & Ground \\
\hline 12 & \(\mathrm{A}_{\text {IN }}\) ¢ & Noninverting input to T/H amplifier. \\
\hline 13 & \(-V_{\text {S }}\) & -5.2 V Power Supply \\
\hline 14 & + \(\mathrm{V}_{\text {s }}\) & +5 V Power Supply \\
\hline 15 - & \(\mathrm{V}_{\mathrm{S}}\) & -5.2 V Power Supply \\
\hline & GND & Ground \\
\hline \[
1
\] & COMP & Should be connected to \(-\mathrm{V}_{\mathrm{S}}\) through \(0.1 \mu \mathrm{~F}\) capacitor. \\
\hline & D11 (MSB) & Most significant bit of ADC output; TTL/CMOS compatible. \\
\hline \[
1925
\] & D10-D4 & Digital output bits of ADC; TTL/CMOS compatible. \\
\hline 26 & \(+\mathrm{V}_{\mathrm{S}}\) & +5 V Power Supply \\
\hline 27 & \(-\mathrm{V}_{\mathrm{S}}\) & -5.2 V Power Supply \\
\hline 28 & GND & Ground \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|}
\hline D3 1 & - & 28 & GND \\
\hline D2 2 & & 27 & \(-V_{s}\) \\
\hline D1 3 & & 26 & \(+V_{s}\) \\
\hline DO (LSB) 4 & & 25 & D4 \\
\hline NC 5 & & 24 & D5 \\
\hline +V5 6 & & 23 & D6 \\
\hline GND 7 & AD9022 & 22 & D7 \\
\hline ENCODE 8 & (Not to Scale) & 21 & D8 \\
\hline GND 9 & & 20 & D9 \\
\hline +V \({ }_{\text {S }} 10\) & & 19 & D10 \\
\hline GND 11 & & 18 & D11 (MSB) \\
\hline \(\mathrm{A}_{\text {IN }} \quad 12\) & & 17 & COMP \\
\hline - \(\mathrm{V}_{5} 13\) & , & 16 & GND \\
\hline +V 14 & & 15 & \(-v_{s}\) \\
\hline NC = NO CON & NNECT & & \\
\hline COMPENSA & ION (PIN 17) SH & HOU & D BE \\
\hline
\end{tabular}

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\section*{AD9022}

\section*{DEFINITIONS OF SPECIFICATIONS}

\section*{Analog Bandwidth}

The analog input frequency at which the spectral power of the fundamental frequency (as determined by FFT analysis) is reduced by 3 dB .

\section*{Aperture Delay}

The delay between the rising edge of the ENCODE command and the instant at which the analog input is sampled.

\section*{Aperture Uncertainty (Jitter)}

The sample-to-sample variation in aperture delay.

\section*{Differential Nonlinearity}

The deviation of any code from an ideal 1 LSB step.

\section*{Harmonic Distortion}

The rms value of the fundamental divided by the rms value of the worst harmonic component.


\section*{Integral Nonlinearity}

The deviation of the transfer function from a reference line measured in fractions of 1 LSB using a "best straight line" determined by a least square curve fit.

\section*{Minimum Conversion Rate}

The encode rate at which the SNR of the lowest analog signal frequency tested drops by no more than 3 dB below the guaranteed limit.

\section*{Maximum Conversion Rate}

The encode rate at which parametric testing is performed.

\section*{Output Propagation Delay}

The delay between the \(50 \%\) point of the rising edge of the ENCODE command and the time when all output data bits are within valid logic levels.

\section*{Overvoltage Recovery Time}

The amount of time required for the converter to recover to 12-bit accuracy after an analog input signal \(150 \%\) of full scale is reduced to the full-scale range of the converter.

\section*{Power Supply Rejection Ratio (PSRR)}

The ratio of a change in input offset voltage to a change in power supply voltage.

Signal-to-Noise Ratio (SNR)
The ratio of the rms signal amplitude to the rms value of "noise," which is defined as the sum of all other spectral components, including harmonics but excluding dc, with an analog input signal 1 dB below full scale.

\section*{Signal-to-Noise Ratio (Without Harmonics)}

The ratio of the rms signal amplitude to the rms value of "noise," which is defined as the sum of all other spectral components, excluding the first five harmonics and dc, with an analog input signal 1 dB below full scale.

\section*{Transient Response}

The time required for the converter to achieve 12-bit accuracy when a step function is applied to the analog input.

Two-Tone Intermodulation Distortion (IMD) Rejection The ratio of the power of either of two input signals to the power of the strongest third-order IMD signal.


Encode Input


Output Stage
Figure 1. Equivalent Circuits

\footnotetext{
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}

\section*{THEORY OF OPERATION}

\section*{Refer to the block diagram.}

The AD9022 employs a three pass subranging architecture and digital error correction. This combination of design techniques ensures 12 -bit accuracy at relatively low power.
Analog input signals are immediately attenuated through a resistor divider and applied directly to the sampling bridge of the track-and-hold (T/H). The T/H holds whatever analog value is present when the unit is strobed with an ENCODE command. The conversion process begins on the rising edge of this pulse, which should conform to the minimum and maximum pulse width requirements shown in the specifications. Operation below the recommended encode rate ( 2 Msps ) may result in excessive droop in the internal T/H devices-leading to large dc and ac errors.
The held analog value of the first track-and-hold is applied to a 5 -bit flash converter and a second T/H. The 5-bit flash converter resolves the most significant bits (MSBs) of the held analog voltage. These 5 bits are reconstructed via a 5 -bit DAC and subtracted from the original \(\mathrm{T} / \mathrm{H}\) output signal to form a residue signal.
A second \(\mathrm{T} / \mathrm{H}\) holds the amplified residue signal while it is encoded with a second 5 -bit flash ADC. Again the 5 bits are reconstructed and subtracted from the second T/H output to form a residue signal. This residue is amplified and encoded with a 4 -bit flash ADC to provide the 3 least significant bits. (LSBs) of the digital output and one bit of error correction. Digital Error Correction logic aligns the data from the three flash converters and presents the result as a 12 -bit parallel digi tal word. The output stage of the AD9022 is TTL. Output data may be strobed on the rising edge of the ENCODE command.

\section*{AD9022 IN RECEIVER APPLICATIONS}

Advances in semiconductor processes have resulted in low cost digital signal processing (DSP) and analog signal processing which can help create cost effective alternative receiver designs. Today, an all-digital receiver allows tuning, demodulation, and detection of receiver signals in the digital domain. By digitizing IF signals directly and utilizing digital techniques, it becomes possible to make significant improvements in receiver design. For high frequency IFs, the ADC is the key to the receiver's performance. Unfortunately, the specifications frequently used by receiver designers and analog-to-digital (ADC) manufacturers are often very different. Noise Figure and Intercept Point are common measures of noise and linearity in analog RF system design. ADCs are more frequently specified in terms of SNR and harmonic distortion.

\section*{Noise}

Noise figure (NF) is a measure of receiver sensitivity and is defined as the degradation of signal-to-noise ratio (SNR) as a signal passes through a device. In equation form:
\[
N F=S N R(i n)-S N R(o u t)
\]

Noise figure is a bandwidth invariant parameter for reasonably narrow bandwidths in most devices. The system noise figure for a combination of amplifiers and mixers, for instance, can be analyzed without regard to the information bandwidth.

Thermal noise contribution from the ADC behaves in a similar fashion; however, the spectral density of quantization noise is a function of the sample rate. In addition, the spectral density of the quantization noise is flat only in an ADC with perfect linearity, i.e., perfect 1 LSB step sizes.
To analyze the system noise performance, ADC noise figure is calculated by normalizing the SNR of the ADC output to a 1 Hz bandwidth. This result is given by:
\[
\begin{gathered}
S N R(/ H z)=S N R+10 \log _{10}(F s / 2) \\
\text { where Fs is the sample rate. }
\end{gathered}
\]

This will be true only for converters in which perfect quantization noise dominates. There may be an upper sample rate, above which the thermal noise of the converter is the dominant source of noise. In this case, normalization would be based on the noise bandwidth of the ADC. For an AD9022 with a typical SNR of 64 dB and a sample rate of 20 Msps , the normalized SNR is equal to \(134 \mathrm{~dB}(64+70)\). Both thermal and quantization noise contribute to this number.
The SNR of the input is assumed to be limited by the thermal noise of the input resistance, or \(-174 \mathrm{dBm} / \mathrm{Hz}\). The input signal level is \(+10 \mathrm{dBm}(2 \mathrm{~V}\) p-p into \(50 \Omega)\). Noise figure of the ADC can be calculated by:
\[
N F=S N R(i n)-S N R(o u t)=[+10-(174)]-134=50 d B
\]

Most ADCs detect input voltage levels, not power. Consequently, the input SNR can be determined more accurately by determining the ratio of the signal voltage to the noise voltage of the terminating resistor. However, both the input signal and noise voltage delivered to the ADC are also a function of the source impedance. The dependence of NF on sample rate, linearity, source and terminating impedances, and the number of assumptions that are required highlight the weakness of using NF as a figure of merit for an ADC. The rather large number that results bolsters this belief by indicating the ADC is often the weakest link in the signal processing path.

\section*{Linearity}

The Third Order intercept point for a linear device (with some nonlinearity) is a good way to predict 3rd order spurious signals as a function of input signal level. For an ADC, however, this in an invalid concept except with signals near full scale. As the input signal is reduced, the performance burden shifts from the input track-and-hold ( \(\mathrm{T} / \mathrm{H}\) ) to the encoder. This creates a nonlinear function, as contrasted with the third order intercept behavior, which predicts an improvement in dynamic range as the signal level is decreased.
For signals near full scale, the intercept point is calculated the same as any device:
\[
\begin{aligned}
& \text { Intercept Point }=[\text { Harmonic Suppression } /(N-1)]+\text { Input Power } \\
& \text { where } N=\text { the order of the } \operatorname{IMD}(3 \mathrm{i} \text { n this case })
\end{aligned} \begin{aligned}
& \text { AD9022 Intercept Point }= 80 / 2+3 \mathrm{dBm}(7 \mathrm{dBm} \text { below full scale }) \\
&=43 \mathrm{dBm}
\end{aligned}
\]

For signals below this level, the spurious free dynamic range (SFDR) curves shown in the data sheet are a more accurate predictor of dynamic range. The SFDR curve is generated by measuring the ratio of the signal (either tone in the two-tone measurement) to the worst spurious signal which is observed as the analog input signal amplitude is swept.

\footnotetext{
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}

The worst spurious signal is usually the second harmonic or 3rd order IMD. Actual results are shown on several plots. The straightline with a slope of one is constructed at the point where the worst SFDR touches the line. This line, extrapolated to full scale, gives the SFDR of the ADC. This value can then be used to predict the dynamic range by simply subtracting the input level from the SFDR. As shown on the two-tone SFDR plot, for example, a signal 20 dB below full scale will always have a dynamic range of at least \(67 \mathrm{~dB}(87 \mathrm{~dB}-20 \mathrm{~dB})\).
It should be noted that all SFDR lines are constructed to be valid only below a certain level below full scale. Above these points, the linearity of the device is dominated by the nonlinearities of the front end and best predicted by the intercept point.

\section*{AD9022 NOISE PERFORMANCE}

High speed, wide bandwidth ADCs such as the AD9022 are optimized for dynamic performance over a wide range of analog input frequencies. However, there are many applications (Imaging, Instrumentation, etc.) where dc precision is also important. Due to the wide input bandwidth of the AD 9022 for a given input voltage, there will be a range of output codes which may occur. This is caused by unavoidable circuit noise within the wideband circuits in the ADC. If a dc signal is applied to the ADC and several thousand outputs are recorded, a distribution of codes such as that shown in the histogram below may result.


Figure 2. \(A D C\) Equivalent Input Noise
The correct code appears most of the time, but adjacent codes also appear with reduced probability. If a normal probability density curve is fitted to this Gaussian distribution of codes, the standard deviation will be equal to the equivalent input rms noise of the ADC. The rms noise may also be approximated by converting the SNR, as measured by a low frequency FFT, to an equivalent input noise. This method is accurate only if the SNR performance is dominated by random thermal noise (the low frequency SNR without harmonics is the best measure). Sixty-three dB equates to 1 LSB rms for a 2 V p-p \((0.707 \mathrm{~V}\) rms ) input signal. The AD9022 has approximately 0.5 LSB of rms noise or a noise limited SNR of 69 dB , indicating that noise alone does not limit the SNR performance of the device (quantization noise and linearity are also major contributors).

This thermal noise may come from several sources. The drive source impedance should be kept low to minimize resistor thermal noise. Some of the internal ADC noise is generated in the wideband T/H. Sampling ADCs generally have input bandwidths which exceed the Nyquist frequency of one-half the sampling rate. (The AD9022 has an input bandwidth of over 100 MHz , even though the sampling rate is limited to 20 Msps .)

Wide bandwidth is required to minimize gain and phase distortion and to permit adequate settling times in the internal amplifiers and T/Hs. But a certain amount of unavoidable noise is generated in the \(\mathrm{T} / \mathrm{H}\) and other wideband circuits within the ADC; this causes variation in output codes for dc inputs. Good layout, grounding, and decoupling techniques are essential to prevent external noise from coupling into the ADC and further corrupting performance.

\section*{USING THE AD9022}

\section*{Layout Information}

Preserving the accuracy and dynamic performance of the AD9022 requires that designers pay special attention to the layout of the printed circuit board.
Analog paths should be kept as short as possible and be properly terminated to ayoid reflections. The analog input connection should be kept away from digital signals paths; this reduces the amount of digital switching noise which is capacitively coupled into the analog section. Digital signal paths should also be kept short, and run lengths should be matched to avoid propagation delay mismatch. The AD9022 digital outputs should be buffered or latched close to the device \((<2 \mathrm{~cm})\). This prevents load transients which may feed back into the device.
In high speed circuits, layout of the ground is critical. A single, low impedance ground plane on the component side of the board is recommended. Power supplies should be capacitively coupled to the ground plane with high quality \(0.1 \mu \mathrm{~F}\) chip capacitors to reduce noise in the circuit. All power pins of the AD9022 should be bypassed individually. The compensation pin (COMP Pin 17) should be bypassed directly to the \(-\mathrm{V}_{\mathrm{S}}\) supply (Pin 15) as close to the part as possible using a \(0.1 \mu \mathrm{~F}\) chip capacitor.
Multilayer boards allow designers to lay out signal traces without interrupting the ground plane, and provide low impedance ground planes. In systems with dedicated analog and digital grounds, all grounds for the AD9022 should be connected to the analog ground plane.
In systems using multilayer boards, dedicated power planes are recommended to provide low impedance connections for device power. Sockets limit dynamic performance and are not recommended for use with the AD9022.

\section*{Timing}

Conversion by the AD9022 is initiated by the rising edge of the ENCODE clock (Pin 8). All required timing is generated internal to the ADC. Care should be taken to ensure that the encode clock to the AD9022 is free from jitter that can degrade dynamic performance. The clock driver should be compatible with TTL LS logic series devices. Drivers with excessive slew rate or overdrive will degrade the dynamic performance of the AD9022.

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Pulse width of the ADC encode clock must be controlled to ensure the best possible performance. Dynamic performance is guaranteed with a clock pulse HIGH minimum of 25 ns . Operation with narrower pulses will degrade SNR and dynamic performance. From a system perspective, this is generally not a problem, because a simple inverter can be used to generate a suitable clock if the system clock is less than 25 ns wide.
The AD9022 provides latched data outputs. Data outputs are available two pipeline delays and one propagation delay after the rising edge of the encode clock (refer to the AD9022 Timing Diagram). The length of the output data lines and the loads placed on them should be minimized to reduce transients within the AD9022; these transients can detract from the converter's dynamic performance.
Operation at encode rates less than 2 Msps is not recommended. The internal track-and-hold saturates, causing erroneous conversions. This T/H saturation precludes clocking the AD9022 in a burst mode.
The duty cycle of the encode clock for the AD9022 is critical for obtaining rated performance of the ADC. Internal pulse widths within the track-and-hold are established by the encode command pulse width; to ensure rated performance, minimum and maximum pulse width restrictions should be observed. Operation at 20 Msps is optimized when the duty cycle is held at \(50 \%\) Duty cycle variations of less than \(\pm 5 \%\) will cause no degradation in performance at 20 Msps .

\section*{Analog Input}

The analog input (Pin 12) voltage range is nominally \(\pm 1.024\) volts. The range is set with an internal voltage reference and cannot be adjusted by the user. The input resistance is \(300 \Omega\) and the analog bandwidth is 100 MHz , making the AD9022 useful in undersampling applications.
The AD9022 should be driven from a low impedance source. The noise and distortion of the amplifier should be considered to preserve the dynamic range of the AD9022.

\section*{Power Supplies}

The power supplies of the AD9022 should be isolated from the supplies used for noisy devices (digital logic especially) to reduce the amount of noise coupled into the ADC. For optimum performance, linear supplies ensure that switching noise from the supplies does not introduce distortion products during the encoding process. If switching supplies must be used, decoupling recommendations above are critically important. The PSRR of the AD9022 as a function of the ripple frequency present on the supplies is shown in the performance graphs. Clearly, power supplies with the lowest possible frequency should be selected.

\section*{AD9022 EVALUATION BOARD}

The evaluation board for the AD9022 (AD9022/PCB) provides an easy and flexible method for evaluating the ADC's performance without (or prior to) developing a user-specific printed circuit board. The two-sided board includes a reconstruction DAC and digital output interface; and uses the layout and applications suggestions outlined above. It is available from Analog Devices at nominal cost.

Generous space is provided near the analog input and digital outputs to support additional signal processing components the user may wish to add. This prototyping area includes through holes with 100 mil centers to support a variety of component additions.

\section*{Input/Output/Supply Information}

Power supply, analog input, clock connections, and reconstructed output (RC OUTPUT) are identified by labels on the evaluation board.
Operation of the evaluation board will conform to the following characteristics:
\begin{tabular}{|c|c|c|}
\hline Parameter & Typical & Units \\
\hline \multicolumn{3}{|l|}{Supply Current} \\
\hline +5 V & 150 & mA \\
\hline -5 V & 300 & mA \\
\hline \multicolumn{3}{|l|}{\(\mathrm{A}_{\text {IN }}\)} \\
\hline Impedance & 51 & \(\Omega\) \\
\hline Voltage Range & \(\pm 1.024\) & V \\
\hline \multicolumn{3}{|l|}{CLOCK} \\
\hline Impedance & 51 & \(\Omega\) \\
\hline Frequency & 20 & Msps \\
\hline \multicolumn{3}{|l|}{RC OUTPUT} \\
\hline 4 Impedance & 51 & \(\Omega\) \\
\hline Voltage Range & 0 to -1 & V \\
\hline
\end{tabular}

Analog Input
Analog input signals can be fed directly into the device under test input \(\left(\mathrm{A}_{\text {IN }}\right)\). The \(\mathrm{A}_{\text {IN }}\) input is terminated at the device with a \(62 \Omega\) resistor to give a parallel equivalent of \(51 \Omega(62 \Omega|\mid 300 \Omega)\).

\section*{DAC Reconstruction}

The AD9022 evaluation board provides an on-board AD9713B reconstruction DAC for observing the digitized analog input signal. The AD9713B is terminated into \(51 \Omega\) to provide a 1 V p-p signal at the output (RC Output).

\section*{Output Data}

The output data bits are latched with two 74LS574 latches which drive a 40 -pin connector (AMP p/n 102153-09). The data and clock signals are available at the connector per the pin assignments shown on the schematic of the evaluation board. Data is latched on the rising edge of the encode clock.

\footnotetext{
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} 12-Bit 20 MSPS

\section*{FEATURES}

\section*{Monolithic}

12-Bit 20 MSPS A/D Converter
Low Power Dissipation: 1.3 Watts
On-Chip T/H and Reference
High-Spurii Free Dynamic Range
ECL Logic

\section*{APPLICATIONS}

Radar Receivers
Digital Communications
Digital Instrumentation
Electro-Optic
Medical Imaging
Digital Filters

\section*{PRODUCT DESCRIPTION}

The AD9023 is a high speed, high performance, monolithic 12bit analog-to-digital converter. All necessary functions, including track-and-hold (T/H) and reference, are included on chip to provide a complete conversion solution. It is a companion unit to the AD 9023 ; the primary difference between the two is that all logic for the AD 9022 is TTL compatible, while the AD 9023 utilizes ECL logic for digital inputs and outputs. Pinouts for the two parts are nearly identical.
Operating from +5 V and -5.2 V supplies, the AD9023 provides excellent dynamic performance. Sampling at 20 Msps with \(\mathrm{A}_{\mathrm{IN}}=1 \mathrm{MHz}\), the spurious free dynamic range (SFDR) is typically 80 dB ; with \(\mathrm{A}_{\text {IN }}=9.6 \mathrm{MHz}, \mathrm{SFDR}\) is 74 dB . SNR is typically 65 dB .
The on-board T/H has a 100 MHz bandwidth and, more importantly, is designed to provide excellent dynamic performance for analog input frequencies above Nyquist. This feature is necessary in many undersampling signal processing applications, such as in direct IF to digital conversion.

To maintain dynamic performance at higher IFs, monolithic RF track-and-holds (such as the AD9100 and AD9101 Samplifier \({ }^{\mathrm{TM}}\) ) can be used with the AD9023 to process signals up to and beyond 70 MHz .

Samplifier is a trademark of Analog Devices, Inc.

FUNCTIONAL BLOCK DIAGRAM


With DNL typically less than 0.5 LSB and 20 ns transient response settling time, the AD9023 provides excellent results when low frequency analog inputs must be over-sampled (such as CCD digitization). The full-scale analog input is \(\pm 1 \mathrm{~V}\) with a \(300 \Omega\) input impedance. The analog input can be driven directly from the signal source, or can be buffered by the AD96xx series of low noise, low distortion buffer amplifiers.
All timing is internal to the AD9023; the clock signal initiates the conversion cycle. For best results, the encode command should contain as little jitter as possible. High speed layout practices must be followed to ensure optimum A/D performance.

The AD9023 is built on a trench isolated bipolar process and utilizes an innovative multipass architecture (see the block diagram). The unit is packaged in 28 -pin ceramic DIPs and gullwing surface mount packages. The AD9023 is specified to operate over the industrial \(\left(-25^{\circ} \mathrm{C}\right.\) to \(\left.+85^{\circ} \mathrm{C}\right)\) and extended \(\left(-55^{\circ} \mathrm{C}\right.\) to \(\left.+125^{\circ} \mathrm{C}\right)\) temperature ranges.

\footnotetext{
This is a preliminary data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.
}

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\section*{NOTES}
\({ }^{1}\) AD 9023 load is a single LS latch.
\({ }^{2}\) RMS signal-to-rms noise with analog input signal 1 dB below full scale at specified frequency.
\({ }^{3}\) Intermodulation measured with analog input frequencies of 9.3 MHz and 9.6 MHz at 7 dB below full scale.
\({ }^{4}\) PSRR is sensitivity of offset error to power supply variations within the \(5 \%\) limits shown.
Specifications subject to change without notice.
\begin{tabular}{|c|c|}
\hline \multicolumn{2}{|l|}{ABSOLUTE MAXIMUM RATINGS \({ }^{1}\)} \\
\hline \(+\mathrm{V}_{\text {S }}\) & +6 V \\
\hline - \(\mathrm{V}_{\text {S }}\) & .-6 V \\
\hline Analog Input & \(-\mathrm{V}_{\mathrm{S}}\) to \(+\mathrm{V}_{\text {S }}\) \\
\hline Digital Inputs & \(-\mathrm{V}_{S}\) to 0 V \\
\hline Digital Output Current & 20 mA \\
\hline Gain Adjust & \(-\mathrm{V}_{\mathrm{S}}\) to \(+\mathrm{V}_{\text {S }}\) \\
\hline Offset Adjust & \(-\mathrm{V}_{\mathrm{S}}\) to \(+\mathrm{V}_{\mathrm{S}}\) \\
\hline \multicolumn{2}{|l|}{Operating Temperature Range (Case)} \\
\hline AD9023AQ/AZ/BQ/BZ & to \(+85^{\circ} \mathrm{C}\) \\
\hline AD9023SQ/SZ/TQ/TZ & 0 \(+125^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}
Maximum Junction Temperature \({ }^{2} \ldots \ldots \ldots \ldots \ldots \ldots .+175^{\circ} \mathrm{C}\)
Lead Temperature (Soldering, 10 sec\() \ldots \ldots \ldots \ldots+300^{\circ} \mathrm{C}\)
Storage Temperature Range \(\ldots \ldots . \ldots . .65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)

NOTES
\({ }^{1}\) Absolute maximum ratings are limiting values to be applied individually, and beyond which the serviceability of the circuit may be impaired. Functional operability is not necessarily implied. Exposure to absolute maximum rating conditions for an extended period of time may affect device reliability.
\({ }^{2}\) Typical thermal impedances: "Q" Package (Ceramic DIP): \(\theta_{\mathrm{JC}}=10^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JA}}=\) \(35^{\circ} \mathrm{C} / \mathrm{W}\). "Z" Package (Gullwing Surface Mount): \(\theta_{\mathrm{JC}}=13^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JA}}=45^{\circ} \mathrm{C} / \mathrm{W}\).

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\section*{Timing Diagram}

ORDERING GUIDE
\begin{tabular}{|c|c|c|c|}
\hline Model & Temperature Range & Package Description & Package Option \\
\hline AD9023AQ/BQ & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 28-Pin Ceramic DIP & Q-28 \\
\hline AD9023AZ/BZ & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 28-Pin Ceramic & Z-28 \\
\hline & & Leaded Chip Carrier & \\
\hline AD9032SQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 28-Pin Ceramic DIP & Q-28 \\
\hline AD9023SZ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 28-Pin Ceramic & Z-28 \\
\hline & & Leaded Chip Carrier & \\
\hline
\end{tabular}
*For outline information see Package Information section.

\section*{EXPLANATION OF TEST LEVELS}

\section*{Test Level}

I - \(100 \%\) production tested.
II - \(100 \%\) production tested at \(+25^{\circ} \mathrm{C}\), and sample tested at specified temperatures. AC testing done on sample basis.
III - Sample tested only.
IV - Parameter is guaranteed by design and characterization testing.
V - Parameter is a typical value only.
VI - All devices are \(100 \%\) production tested at \(+25^{\circ} \mathrm{C}\); guaranteed by design and characterization testing at temperature extremes for industrial devices.

DIE LAYOUT AND MECHANICAL INFORMATION
Die Dimensions . . . . . . . . . . . . . . . \(205 \times 228 \times 21( \pm 1)\) mils
Pad Dimensions . . . . . . . . . . . . . . . . . . . . . . . . . . . . \(4 \times 4\) mils
Metalization . . . . . . . . . . . . . . . . . . . . . . . . . . . . Aluminum
Backing . \(\sim\). . . . . . . . . . . . . . . . . . . . . . . . . . . . . . None
Substrate Potential . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . - V \(_{\text {S }}\)
Transistor Count . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 4, 128
Passivation . . . . . . . . . . . . . . . . . . . . . . . . . . . . . Oxynitride
Die Attach . . . . . . . . . . . . . . . . . . . . . . . . . . . . . Silver Glass
Bond Wire . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . Aluminum


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PIN DESCRIPTION
\begin{tabular}{|c|c|c|}
\hline Pin No. & Name & Function \\
\hline 1-3 & D3-D1 & Digital output bits of ADC; ECL compatible. \\
\hline 4 & D0 (LSB) & Least significant bit of ADC output; ECL compatible. \\
\hline 5 & \(\overline{\text { ENCODE }}\) & Complementary encode input to ADC. \\
\hline 6 & NC & No Connect \\
\hline 7 & GND & Ground \\
\hline 8 & ENCODE & Encode clock input to ADC. Internal \(\mathrm{T} / \mathrm{H}\) is placed in hold mode (ADC is encoding) on rising edge of encode signal. \\
\hline 9 & GND & Ground \\
\hline 10 & \(+\mathrm{V}_{\text {S }}\) & +5 V Power Supply \\
\hline 11 & GND & Ground \\
\hline 12 & \(\mathrm{A}_{\text {IN }}\) & Noninverting input to \(\mathrm{T} / \mathrm{H}\) amplifier. \\
\hline 13 & - \(\mathrm{V}_{\text {S }}\) & -5.2 V Power Supply \\
\hline 14 & \(+\mathrm{V}_{\text {S }}\) & +5 V Power Supply \\
\hline 15 & - \(\mathrm{V}_{\text {s }}\) & -5.2 V Power Supply \\
\hline 16 & GND & Ground \\
\hline 17 & COMP & Should be connected to \(-\mathrm{V}_{\mathrm{S}}\) through \(0.1 \mu \mathrm{~F}\) capacitor. \\
\hline 18 & D11 (MSB) & Most significant bit of ADC output; ECL compatible. \\
\hline 19-25 & D10-D4 & Digital output bits of ADC; ECL compatible. \\
\hline 26 & \(+\mathrm{V}_{\text {S }}\) & +5 V Power Supply \\
\hline 27 & - \(\mathrm{V}_{\text {S }}\) & -5.2 V Power Supply \\
\hline 28 & GND & Ground \\
\hline
\end{tabular}

PIN DESIGNATIONS


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\section*{THEORY OF OPERATION}

Refer to the block diagram. The AD9023 employs a three pass subranging architecture and digital error correction. This combination of design techniques insures 12-bit accuracy at relatively low power.

Analog input signals are immediately attenuated through a resistor divider and applied directly to the sampling bridge of the track-and-hold ( \(\mathrm{T} / \mathrm{H}\) ). The \(\mathrm{T} / \mathrm{H}\) holds whatever analog value is present when the unit is strobed with an ENCODE command. The conversion process begins on the rising edge of this pulse, which should conform to the minimum and maximum pulse width requirements shown in the specifications. Operation below the recommended encode rate ( 2 Msps ) may result in excessive droop in the internal \(\mathrm{T} / \mathrm{H}\) devices-leading to large dc and ac errors.
The held analog value of the first track-and-hold is applied to a 5-bit flash converter and a second T/H. The 5-bit flash converter resolves the most significant bits (MSBs) of the held analog voltage. These 5 bits are reconstructed via a 5 -bit DAC and subtracted from the original \(\mathrm{T} / \mathrm{H}\) output signal to form a residue signal.
A second \(\mathrm{T} / \mathrm{H}\) holds the amplified residue signal while it is encoded with a second 5 -bit flash ADC. Again the 5 bits are reconstructed and subtracted from the second T/H output to form a residue signal. This residue is amplified and encoded with a 4bit flash ADC to provide the 3 least significant bits (LSBs) of the digital output and one bit of error correction.

Digital Error Correction logic aligns the data from the three flash converters and presents the result as a 12-bit parallel digital word. The output stage of the AD9023 is TTL. Output data may be strobed on the rising edge of the ENCODE command.

\section*{AD9023 Noise Performance}

High speed, wide bandwidth ADCs such as the AD9023 are optimized for dynamic performance over a wide range of analog input frequencies. However, there are many applications (Imaging, Instrumentation, etc.) where dc precision is also important. Due to the wide input bandwidth of the AD 9023 for a given input voltage, there will be a range of output codes which may occur. This is caused by unavoidable circuit noise within the wideband circuits in the ADC. If a dc signal is applied to the \(A D C\) and several thousand outputs are recorded, a distribution of codes such as that shown in the histogram below may result.


Figure 2. Equivalent Input Noise

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The correct code appears most of the time, but adjacent codes also appear with reduced probability. If a normal probability density curve is fitted to this Gaussian distribution of codes, the standard deviation will be equal to the equivalent input rms noise of the ADC. The rms noise may also be approximated by converting the SNR, as measured by a low frequency FFT, to an equivalent input noise. This method is accurate only if the SNR performance is dominated by random thermal noise (the low frequency SNR without harmonics is the best measure). Sixty-three dB equates to 1 LSB rms for a 2 V p-p ( 0.707 V rms ) input signal. The AD9023 has approximately 0.5 LSB of rms noise or a noise limited SNR of 69 dB , indicating that noise alone does not limit the SNR performance of the device (quantization noise and linearity are also major contributors).

This thermal noise may come from several sources. The drive source impedance should be kept low to minimize resistor thermal noise. Some of the internal ADC noise is generated in the wideband T/H. Sampling ADCs generally have input bandwidths which exceed the Nyquist frequency of one-half the sampling rate. (The AD9023 has an input bandwidth of over 100 MHz , even though the sampling rate is limited to 20 Msps .)

\section*{USING THE AD9023}

\section*{Layout Information}

Preserving the accuracy and dynamic performance of the AD9023 requires that designers pay special attention to the layout of the printed circuit board.
Analog paths should be kept as short as possible and be properly terminated to avoid reflections. The analog input connection: should be kept away from digital signals paths; this reduces the amount of digital switching noise which is capacitively coupled into the analog section. Digital signal paths should also be kept short, and run lengths should be matched to avoid propagation delay mismatch. The AD9023 digital outputs should be buffered or latched close to the device ( \(<2 \mathrm{~cm}\) ). This prevents load transients which may feed back into the device.

In high speed circuits, layout of the ground is critical. A single, low impedance ground plane on the component side of the board is recommended. Power supplies should be capacitively coupled to the ground plane with high quality \(0.1 \mu \mathrm{~F}\) chip capacitors to reduce noise in the circuit. All power pins of the AD9023 should be bypassed individually. The compensation pin (COMP Pin 17) should be bypassed directly to the \(-V_{S}\) supply (Pin 15) as close to the part as possible using a \(0.1 \mu \mathrm{~F}\) chip capacitor.
Multilayer boards allow designers to lay out signal traces without interrupting the ground plane, and provide low impedance ground planes. In systems with dedicated analog and digital grounds, all grounds for the AD9023 should be connected to the analog ground plane.
In systems using multilayer boards, dedicated power planes are recommended to provide low impedance connections for device power. Sockets limit dynamic performance and are not recommended for use with the AD9023.

Timing
Conversion by the AD9023 is initiated by the rising edge of the ENCODE clock (Pin 8). All required timing is generated internal to the ADC. Care should be taken to ensure that the encode clock to the AD9023 is free from jitter that can degrade dynamic performance.
Pulse width of the ADC encode clock must be controlled to ensure the best possible performance. Dynamic performance is guaranteed with a clock pulse HIGH minimum of 25 ns . Operation with narrower pulses will degrade SNR and'dynamic performance. From a system perspective, this is generally not a problem because a simple inverter can be used to generate a suitable clock if the system clock is less than 25 ns wide.
The AD9023 provides latched data outputs. Data outputs are available two pipeline delays and one propagation delay after the rising edge of the encode clock (refer to the AD9023 Timing Diagram). The length of the output data lines and the loads placed on them should be minimized to reduce transients within the AD9023; these transients can detract from the converter's dynamic performance. Operation at encode rates less than 2 Msps is not recommended. The internal track-and-hold saturates, causing erroneous conversions. This \(\mathrm{T} / \mathrm{H}\) saturation precludes clocking the AD9023 in a burst mode.
The duty cycle of the encode clock for the AD9023 is critical for obtaining rated performance of the ADC. Internal pulse widths within the track-and-hold are established by the encode command pulse width; to ensure rated performance, minimum and maximum pulse width restrictions should be observed. Operation at 20 Msps is optimized when the duty cycle is held at \(50 \%\). Duty cycle variations of less than \(\pm 5 \%\) will cause no degradation in performance at 20 Msps .

\section*{Analog Input}

The analog input (Pin 12) voltage range is nominally \(\pm 1.024\) volts. The range is set with an internal voltage reference and cannot be adjusted by the user. The input resistance is \(300 \Omega\) and the analog bandwidth is 100 MHz , making the AD9023 useful in undersampling applications.
The AD9023 should be driven from a low impedance source: The noise and distortion of the amplifier should be considered to preserve the dynamic range of the AD9023.

\section*{Power Supplies}

The power supplies of the AD9023 should be isolated from the supplies used for noisy devices (digital logic especially) to reduce the amount of noise coupled into the ADC. For optimum performance, linear supplies ensure that switching noise from the supplies does not introduce distortion products during the encoding process. If switching supplies must be used, decoupling recommendations above are critically important. The PSRR of the AD 9023 as a function of the ripple frequency present on the supplies is shown in the performance graphs. Clearly, power supplies with the lowest possible frequency should be selected.

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12-Bit, 31 MSPS

\section*{FEATURES}

12-Bit 31 MSPS A/D Converter
Low Power Dissipation: 1.5 Watts
On-Chip T/H and Reference Wide Spurious-Free Dynamic Range
ECL Logic

\section*{APPLICATIONS}

Cellular Base Stations
Communications Receivers
Radar Receivers
Spectrum Analyzers
Electro-Optics
Medical Imaging

\section*{PRODUCT DESCRIPTION}

The AD9027 is a high speed, high performance, monolithic 12 bit analog-to-digital converter. All necessary functions, including track-and-hold ( \(\mathrm{T} / \mathrm{H}\) ) and reference, are included on chip to provide a complete conversion solution.
It is a companion unit to the AD 9026 ; the primary difference between the two is that all logic for the AD9026 is TTL compatible, while the AD9027 utilizes ECL logic for digital inputs and outputs. Pinouts for the two parts are nearly identical.
The on-board T/H has a 200 MHz bandwidth and, more importantly, is designed to provide excellent dynamic performance for analog input frequencies above Nyquist. This feature is necessary in many undersampling signal processing applications, such as in direct IF-to-digital conversion. In addition, wide spurious-free dynamic range (SFDR) over the entire Nyquist bandwidth makes the AD9027 well suited for multichannel transceiver applications which need to digitize bandwidths up to 15 MHz .

\section*{FUNCTIONAL BLOCK DIAGRAM}


All timing is internal to the AD9027; the clock signal initiates the conversion cycle, For best results, the encode command should contain as little jitter as possible. High speed layout practices must be followed to ensure optimum \(\mathrm{A} / \mathrm{D}\) performance. The AD9027 is built on a trench isolated bipolar process and utilizes an innovative multipass architecture (see the block diagram) The unit is packaged in a 28 -pin ceramic DIP; the custom cofired ceramic package forms a multilayer substrate to which are attached internal bypass capacitors and the AD9027 die. The AD9027 is specified to operate over the industrial \(\left(-25^{\circ} \mathrm{C}\right.\) to \(\left.+85^{\circ} \mathrm{C}\right)\) temperature range.

This is a preliminary data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.



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\begin{tabular}{|c|c|c|c|c|c|c|}
\hline Parameter (Conditions) & \begin{tabular}{l}
Test \\
Temp
\end{tabular} & Level & Min & \[
\begin{aligned}
& 9027 \mathrm{AD} \\
& \text { Typ } \\
& \hline
\end{aligned}
\] & Max & Units \\
\hline \begin{tabular}{l}
DIGITAL OUTPUTS \({ }^{1}\) \\
Logic Compatibility \\
Logic " 1 " Voltage \\
Logic "0" Voltage \\
Output Coding
\end{tabular} & \begin{tabular}{l}
Full \\
Full
\end{tabular} & \[
\begin{aligned}
& \text { VI } \\
& \text { VI }
\end{aligned}
\] & -1.1 & \begin{tabular}{l}
ECL \\
Binary
\end{tabular} & -1.5 & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{~V}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
POWER SUPPLY \\
\(+V_{\text {S }}\) Supply Voltage \\
\(+V_{\text {S }}\) Supply Current \\
- \(V_{S}\) Supply Voltage \\
- \(\mathrm{V}_{\text {S }}\) Supply Current \\
Power Dissipation \\
Power Supply \\
Rejection Ratio (PSRR) \({ }^{4}\)
\end{tabular} & \begin{tabular}{l}
Full \\
Full \\
Full \\
Full \\
Full \\
Full
\end{tabular} & \begin{tabular}{l}
VI \\
VI \\
VI \\
VI \\
VI \\
IV
\end{tabular} & 4.75
5.45 & \begin{tabular}{l}
5.0 \\
112 \\
-5.2 \\
180 \\
1.5 \\
12
\end{tabular} & 5.25
-4.95 & \begin{tabular}{l}
V \\
mA \\
V \\
mA \\
W \\
\(\mathrm{mV} / \mathrm{V}\)
\end{tabular} \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1} \mathrm{AD} 9027\) is terminated into 5.2 V through 2,000 ohms.
\({ }^{2}\) Analog input signal is 1 dB below full scale at specified frequency.
\({ }^{3}\) Intermodulation measured with analog input frequencies of 9.6 MHz and 11.3 MHz at 7 dB below full scale.
\({ }^{4}\) PSRR is sensitivity of offset error to power supply variations within the \(5 \%\) limits shown.
Specifications subject to change without notice.

ABSOLUTE MAXIMUM RATINGS \({ }^{1}\)
\(+V_{S}\)
- \(\mathrm{V}_{\mathrm{S}}\). . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . \(4 . \mathrm{H}_{-6 \mathrm{~V}}\)

Analog Input . . . . . . . . . . . . . . . . . . . . . . . . . . . . 42.5 V
Digital Inputs . . . . . . . . . . . . . . . . . . . . . . . . . . .. . \(-V_{s}\) to 0 V
Digital Output Current . . . . . . . . . . . . . . . . . . . . . . 20 mA
Operating Temperature Range (Case) . . . . . . \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
Maximum Junction Temperature \({ }^{2} \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots+175^{\circ}\)
Lead Temperature (Soldering, 10 sec ) . . . . . . . . . . . . \(+300^{\circ} \mathrm{C}\)
Storage Temperature Range . . . . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
NOTES
\({ }^{1}\) Absolute maximum ratings are limiting values to be applied individually, and beyond which the serviceability of the circuit may be impaired. Functional operability is not necessarily implied. Exposure to absolute maximum rating conditions for an extended period of time may affect device reliability.
\({ }^{2}\) Typical thermal impedances: " Q " Package (Ceramic DIP): \(\theta_{\mathrm{JC}}=\mathrm{x}^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JA}}=\) \(x^{\circ} \mathrm{C} / \mathrm{W}\).

\section*{EXPLANATION OF TEST LEVELS}

Test Level
I. - \(100 \%\) production tested.

II - \(100 \%\) production tested at \(+25^{\circ} \mathrm{C}\), and sample tested at specified temperatures. AC testing done on sample basis.
III - Sample tested only.
IV - Parameter is guaranteed by design and characterization testing.
V - Parameter is a typical value only.
VI - All devices are \(100 \%\) production tested at \(+25^{\circ} \mathrm{C} ; 100 \%\) production tested at temperature extremes for extended temperature devices; guaranteed by design and characterization testing for industrial devices.

\section*{ORDERING GUIDE}
\begin{tabular}{l|l|l}
\hline Device & Temperature Range & Package Option \\
\hline AD9027AD & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\mathrm{DH}-28\) \\
\hline
\end{tabular}
*For outline information see Package Information section.

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PIN DESCRIPTION
\begin{tabular}{|c|c|c|}
\hline Pin No. & Name & Function \\
\hline 1-3 & D3-D1 & Digital output bits of ADC; ECL compatible. \\
\hline 4 & D0 (LSB) & Least significant bit of ADC output; ECL compatible. \\
\hline 5 & ENCODE & Complement of encode clock input. \\
\hline 6 & NC & No connection internally. \\
\hline 7 & GND & Ground. \\
\hline 8 & ENCODE & Encode clock input to ADC. Internal \(\mathrm{T} / \mathrm{H}\) is placed in hold mode (ADC is encoding) on rising edge of encode signal. \\
\hline 9 & GND & Ground. \\
\hline 10 & +V & +5 V power supply. \\
\hline 11 & GND & Ground. \\
\hline 12 & \(\mathrm{A}_{\mathrm{IN}}\) & Noninverting input to T/H amplifier. \\
\hline 13 & - \(\mathrm{V}_{\text {S }}\) & -5.2 V power supply. \\
\hline 14 & \(+\mathrm{V}_{\text {S }}\) & +5 V power supply. \\
\hline 15 & - \(\mathrm{V}_{\text {S }}\) & -5.2 V power supply. \\
\hline 16 & GND & Ground. \\
\hline 17 & BYPASS & Should be connected to \(-V_{S}\) through \(0.1 \mu \mathrm{~F}\) capacitor. \\
\hline 18 & D11 (MSB) & Most significant bit of ADC output; ECL compatible. \\
\hline 19-25 & D10-D4 & Digital output bits of ADC; ECL compatible. \\
\hline 26 & + \(\mathrm{V}_{\text {S }}\) & +5 V power supply. \\
\hline 27 & - \(\mathrm{V}_{\text {S }}\) & -5.2 V power supply. \\
\hline 28 & GND & Ground. \\
\hline
\end{tabular}

DIE LAYOUT AND MECHANICAL INFORMATION
Die Dimensions . . . . . . . . . . . . . . . . \(205 \times 228 \times 21( \pm 1)\) mils Pad Dimensions . . . . . . . . . . . . . . . . . . . . . . . . . . . . . \(4 \times 4\) mils Metalization . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . Aluminum
Backing . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . None

Substrate Potential . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . - V \(_{\text {S }}\)
Transistor Count . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 4,336
Passivation . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . Oxynitride
Die Attach . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . Silver Filled
Bond Wire . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . Gold


PIN DESIGNATIONS

AD9027 Chip Pinouts


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\section*{DEFINITIONS OF SPECIFICATIONS}

\section*{Analog Bandwidth}

The analog input frequency at which the spectral power of the fundamental frequency (as determined by FFT analysis) is reduced by 3 dB .

\section*{Aperture Delay}

The delay between the \(50 \%\) point of the rising edge of the ENCODE command and the instant at which the analog input is sampled.
Aperture Uncertainty (Jitter)
The sample-to-sample variation in aperture delay.

\section*{Differential Nonlinearity}

The deviation of any code from an ideal 1 LSB step.

\section*{Harmonic Distortion}

The rms value of the fundamental divided by the rms value of the worst harmonic component.
Integral Nonlinearity
The deviation of the transfer function from a reference line measured in fractions of 1 LSB using a "best straight line" determined by a least square curve fit.

\section*{Minimum Conversion Rate}

The encode rate at which the SNR of the lowest analog signal frequency tested drops by no more than 3 dB below the guaranteed limit.

\section*{Maximum Conversion Rate}

The encode rate at which parametric testing is performed

\section*{Output Propagation Delay}

The delay between the \(50 \%\) point of the rising edge of the ENCODE command and the time when all output data bits are within valid logic levels.
Overvoltage Recovery Time
The amount of time required for the converter to recover to 12-bit accuracy after an analog input signal \(150 \%\) of full scale is reduced to midscale.

\section*{Power Supply Rejection Ratio (PSRR)}

The ratio of a change in input offset voltage to a change in power supply voltage.

\section*{Signal-to-Noise-and-Distortion (SINAD)}

The ratio of the rms signal amplitude to the rms value of "noise," which is defined as the sum of all other spectral components, including harmonics but excluding dc, with an analog input signal 1 dB below full scale.

\section*{Signal-to-Noise Ratio (Without Harmonics)}

The ratio of the rms signal amplitude to the rms value of "noise," which is defined as the sum of all other spectral components, excluding the first five harmonics and dc, with an analog input signal 1 dB below full scale.

\section*{Transient Response}

The time required for the converter to achieve 12-bit accuracy when a one-half full-scale step function is applied to the analog input.
Two-Tone Intermodulation Distortion (IMD) Rejection The ratio of the power of either of two input signals to the power of the strongest third-order IMD signal.


Encode Input


Bypass


Output Stage
Equivalent Circuits

\section*{THEORY OF OPERATION}

\section*{Refer to the block diagram.}

The AD9027 employs a three-pass subranging architecture and digital error correction. This combination of design techniques ensures 12 -bit accuracy at relatively low power.
Analog input signals are immediately attenuated through a resistor divider and applied directly to the sampling bridge of the track-and-hold (T/H). The T/H holds whatever analog value is present when the unit is strobed with an ENCODE command. The conversion process begins on the rising edge of this pulse, which should conform to the minimum and maximum pulse width requirements shown in the specifications. Operation below the recommended encode rate ( 4 Msps ) may result in excessive droop in the internal T/H devices-leading to large dc and ac errors.

The held analog value of the first track-and-hold is applied to a 5-bit flash converter and a second T/H. The 5-bit flash converter resolves the most significant bits (MSBs) of the held ana\(\log\) voltage. These five bits are reconstructed via a 5 -bit DAC and subtracted from the original \(T / H\) output signal to form a residue signal.
A second \(T / H\) holds the amplified residue signal while it is encoded with a second 5-bit flash ADC. Again the five bits are reconstructed and subtracted from the second T/H output to form a residue signal. This residue is amplified and encoded with a 4-bit flash ADC to provide the three least significant bits (LSBs) of the digital output and one bit of error correction.
Digital error correction logic aligns the data from the three flash converters and presents the result as a 12-bit parallel digital word. The output stage of the AD9027 is ECL. Output data may be strobed on the rising edge of the ENCODE command.

\section*{AD9027 NOISE PERFORMANCE}

High speed, wide bandwidth ADCs such as the AD9027 are optimized for dynamic performance over a wide range of analog input frequencies. However, there are many applications (imaging, instrumentation, etc.) where dc precision is also important. Due to the wide input bandwidth of the AD9027 for a given input voltage, there will be a range of output codes that may occur. This is caused by unavoidable circuit noise within the wideband circuits in the ADC. If a dc signal is applied to the ADC and several thousand outputs are recorded, a distribution of codes such as that shown in the histogram may result.
The correct code appears most of the time, but adjacent codes also appear with reduced probability. If a normal probability density curve is fitted to this Gaussian distribution of codes, the
standard deviation will be equal to the equivalent input rms noise of the ADC. The rms noise may also be approximated by converting the SNR, as measured by a low frequency FFT, to an equivalent input noise. This method is accurate only if the SNR performance is dominated by random thermal noise (the low frequency SNR without harmonics is the best measure); 63 dB equates to 1 LSB rms for a 2 V p-p ( 0.707 V rms ) input signal.


The AD9027 has approximately 0.7 LSB of rms noise or a noise limited SNR of 66 dB , indicating that thermal noise alone does not limit the SNR performance of the device (quantization noise and linearity are also major contributors).
This thermal noise may come from several sources. The drive source impedance should be kept low to minimize resistor thermal noise. Some of the internal ADC noise is generated in the wideband T/H. Sampling ADCs generally have input bandwidths which exceed the Nyquist frequency of one-half the sampling rate. (The AD9027 has an input bandwidth of approximately 200 MHz , even though the sampling rate is limited to 31 Msps.)
Wide bandwidth is required to minimize gain and phase distortion and to permit adequate settling times in the internal amplifiers and T/Hs. But a certain amount of unavoidable noise is generated in the \(\mathrm{T} / \mathrm{H}\) and other wideband circuits within the ADC; this causes variation in output codes for dc inputs. Good layout, grounding, and decoupling techniques are essential to prevent external noise from coupling into the ADC and further corrupting performance.

\footnotetext{
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}

\section*{USING THE AD9027}

\section*{Layout Information}

Preserving the accuracy and dynamic performance of the AD9027 requires that designers pay special attention to the layout of the printed circuit board.

Analog paths should be kept as short as possible and be properly terminated to avoid reflections. The analog input connection should be kept away from digital signals paths; this reduces the amount of digital switching noise which is capacitively coupled into the analog section. Digital signal paths should also be kept short, and run lengths should be matched to avoid propagation delay mismatch. The AD9027 digital outputs should be buffered or latched close to the device ( \(<2 \mathrm{~cm}\) ). This prevents load transients which may feed back into the device.
In high speed circuits, layout of the ground is critical. A single, low impedance ground plane on the component side of the board is recommended. Power supplies should be capacitively coupled to the ground plane with high quality \(0.1 \mu \mathrm{~F}\) chip capacitors to reduce noise in the circuit. All power pins of the AD9027 should be bypassed individually. The bypass pin (BYPASS Pin 17) should be bypassed directly to the \(-\mathrm{V}_{\mathrm{S}}\) supply (Pin 15) as close to the part as possible using a \(0.1 \mu \mathrm{~F}\) chip capacitor.
Multilayer boards allow designers to lay out signal traces without interrupting the ground plane, and provide low impedance ground planes. In systems with dedicated analog and digital grounds, all grounds for the AD9027 should be connected to the analog ground plane.
In systems using multilayer boards, dedicated power planes are recommended to provide low impedance connections for device power. Sockets limit dynamic performance and are not recommended for use with the AD9027.

\section*{Timing}

Conversion by the AD9027 is initiated by the rising edge of the ENCODE clock (Pin 8). All required timing is generated internal to the ADC. Care should be taken to ensure that the encode clock to the AD9027 is free from jitter that can degrade dynamic performance. The clock driver should be differential ECL. Drivers with excessive slew rate or overdrive will degrade the dynamic performance of the AD9027.
Pulse width of the ADC encode clock must be controlled to insure the best possible performance. The duty cycle of the encode clock for the AD9027 is critical for obtaining rated performance of the ADC. Internal pulse widths within the track-and-hold are established by the encode command pulse width; to ensure rated performance, minimum and maximum pulse width restrictions should be observed. Operation at 31 Msps is optimized when the duty cycle is held at \(50 \%\). Duty cycle variations of less than \(\pm 5 \%\) will cause no degradation in performance at 31 Msps .

The AD9027 provides latched data outputs. Data outputs are available two pipeline delays and one propagation delay after the rising edge of the encode clock (refer to the AD9027 Timing Diagram). The length of the output data lines and the loads placed on them should be minimized to reduce transients within the AD9027; these transients can detract from the converter's dynamic performance.
Operation at encode rates less than 4 Msps is not recommended. The internal track-and-hold saturates, causing erroneous conversions. This T/H saturation precludes clocking the AD9027 in a burst mode.

\section*{Analog Input}

The Analog Input (Pin 12) voltage range is nominally \(\pm 1.024 \mathrm{~V}\). The range is set with an internal voltage reference and can not be adjusted by the user. The input resistance is \(300 \Omega\) and the analog bandwidth is 200 MHz , making the AD9027 useful in undersampling applications.
The AD9027 should be driven from a low impedance source. The noise and distortion of the amplifier should be considered to preserve the dynamic range of the AD9027.

\section*{Power Supplies}

The power supplies of the AD9027 should be isolated from the supplies used for noisy devices (digital logic especially) to reduce the amount of noise coupled into the ADC. For optimum performance, linear supplies ensure that switching noise from the supplies does not introduce distortion products during the encoding process. If switching supplies must be used, decoupling recommendations above are critically important. The PSRR of the AD9027 as a function of the ripple frequency present on the supplies is shown in the performance graphs. Clearly, power supplies with the lowest possible frequency should be selected.


Figure 2. Timing Diagram

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.


Figure 3.

Figure 4.

...


Figure 5.


Figure 6.

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

\section*{FEATURES}

\author{
25.6 MSPS Conversion Speeds \\ On-Board T/H, References, Timing \\ Low Power: 3.8 W \\ Single 40-Pin Package \\ 74 dB Spurious-Free Dynamic Range \\ to \(12 \mathrm{MHz} \mathrm{A}_{\mathrm{IN}}\) \\ Bipolar Input: \(\pm 1.024\) V
}

APPLICATIONS
Radar
Signal Intelligence
Digital Spectrum Analyzers
Medical Imaging
Electro-Optics

\section*{GENERAL DESCRIPTION}

The AD9032 is the world's fastest 12 -bit analog-to-digital converter (ADC) that includes on-board T/H, voltage references, and timing circuits. The AD9032 uses a subranging converter architecture to achieve sample rates from dc to 25.6 Msps . Packaged in a single 40 -pin hybrid, the AD9032 is pin-compatible with the AD9034, which operates at word rates up to 20 Msps .
This ECL-compatible ADC requires only +5 V and -5.2 V supplies, an analog input, and a stable ECL clock to obtain the best dynamic performance available in a 12 -bit ADC. This kind of performance is achieved with advanced bipolar circuits, custom designed and manufactured by Analog Devices. The latest in monolithic track-and-hold technology ensures accurate sampling of high frequency analog inputs.
Dynamic performance has been optimized to achieve SNR of 64 dB and a spurious-free dynamic range (SFDR) of 74 dB for analog bandwidths up to 12 MHz . All units are tested for dynamic performance at a sample rate of 25.6 Msps .
The AD9032 is available in either a 40 -pin ceramic DIP or leaded flatpack. The two versions operate over an industrial \(\left(-25^{\circ} \mathrm{C}\right.\) to \(\left.+85^{\circ} \mathrm{C}\right)\) or military \(\left(-55^{\circ} \mathrm{C}\right.\) to \(\left.+125^{\circ} \mathrm{C}\right)\) temperature range.

FUNCTIONAL BLOCK DIAGRAM


\section*{EVALUATION BOARD}

An evaluation board which is available for the AD9032 (part number AD9034/PCB) provides an easy and flexible method for evaluating the ADC's performance without (or prior to) developing a user-specified printed circuit board. The evaluation board was originally designed and used for evaluating the AD9034 A/D converter, but is equally useful for the pin-compatible AD9032.
The board includes a reconstruction DAC, analog input amplifier, and digital output interface. Physically, it is 7.25 inches \(\times\) 6 inches in size and uses the layout and applications information contained in the AD9034 data sheet.

Generous space is provided near the analog input and digital outputs of the evaluation board to support additional signal processing components the user may wish to add. These two prototyping areas include through holes with 100 -mil centers to support a variety of component additions.
For additional operating details, a schematic of the evaluation board, and complete layout information, consult the data sheet on the AD9034 A/D converter.

\section*{AD9032-SPECIFICATIONS}

\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Parameter (Conditions)} & \multirow[b]{2}{*}{Temp} & \multirow[t]{2}{*}{\begin{tabular}{l}
Test \\
Level
\end{tabular}} & \multicolumn{3}{|r|}{AD9032AD/AZ} & \multicolumn{3}{|r|}{AD9032BD/BZ} & \multicolumn{3}{|r|}{AD9032TD/TZ} & \multirow[b]{2}{*}{Units} \\
\hline & & & Min & Typ & Max & Min & Typ & Max & Min & Typ & Max & \\
\hline RESOLUTION & & & \multicolumn{3}{|l|}{12} & \multicolumn{3}{|l|}{12} & \multicolumn{3}{|l|}{12} & Bits \\
\hline DC ACCURACY & & & \multicolumn{3}{|l|}{} & \multicolumn{3}{|l|}{} & \multicolumn{3}{|l|}{} & \multirow[b]{3}{*}{\[
\begin{aligned}
& \text { LSB } \\
& \text { LSB }
\end{aligned}
\]} \\
\hline Differential Nonlinearity & \(+25^{\circ} \mathrm{C}\) & & \multicolumn{2}{|r|}{\multirow[t]{2}{*}{0.65}} & \multirow[t]{2}{*}{\[
\begin{aligned}
& 1.25 \\
& 1.75
\end{aligned}
\]} & \multirow[t]{4}{*}{} & \multirow[t]{2}{*}{0.5} & \multirow[t]{2}{*}{\[
\begin{aligned}
& 1.0 \\
& 1.5
\end{aligned}
\]} & \multirow[t]{4}{*}{} & \multirow[t]{2}{*}{0.5} & \multirow[t]{2}{*}{\[
\begin{aligned}
& 1.0 \\
& 1.5
\end{aligned}
\]} & \\
\hline & Full & VI & & & & & & & & & & \\
\hline Integral Nonlinearity & \(+25^{\circ} \mathrm{C}\) & V & \multicolumn{3}{|c|}{1.0} & & \multicolumn{2}{|l|}{1.0} & & \multicolumn{2}{|l|}{1.0} & LSB \\
\hline & Full & V & & \[
2.0
\] & & & \multicolumn{2}{|l|}{2.0} & & \multicolumn{2}{|l|}{2.0} & LSB \\
\hline No Missing Codes & Full & VI & \multicolumn{3}{|r|}{Guaranteed} & & \multicolumn{2}{|l|}{Guaranteed} & & \multicolumn{2}{|l|}{Guaranteed} & \multirow[b]{5}{*}{\[
\begin{aligned}
& \mathrm{mV} \\
& \mathrm{mV} \\
& \% \text { FS } \\
& \% \text { FS }
\end{aligned}
\]} \\
\hline Offset Error & \(+25^{\circ} \mathrm{C}\) & I & & & 15 & & & 15 & & & 15 & \\
\hline & Full & VI & & & 25 & & & 25 & & & 30 & \\
\hline Gain Error & \(+25^{\circ} \mathrm{C}\) & I & & \(\pm 0.5\) & \(\pm 1.0\) & & \(\pm 0.5\) & \(\pm 1.0\) & & \(\pm 0.5\) & \(\pm 1.0\) & \\
\hline & Full & VI & & & \(\pm 2.5\) & & & \(\pm 2.5\) & & & \(\pm 2.5\) & \\
\hline \multicolumn{13}{|l|}{ANALOG INPUT} \\
\hline Input Voltage Range & \(+25^{\circ} \mathrm{C}\) & 1 & & \(\pm 1.02\) & & & \(\pm 1.02\) & & & \(\pm 1.02\) & & \\
\hline Input Resistance & \(+25^{\circ} \mathrm{C}\) & VI & 95 & 100 & 105 & 95 & 100 & 105 & 95 & 100 & 105 & \(\Omega\) \\
\hline Input Capacitance & \(+25^{\circ} \mathrm{C}\) & IV & & 7 & 10 & & & 10 & & 7 & 10 & pF \\
\hline Analog Bandwidth & \(+25^{\circ} \mathrm{C}\) & IV & 150 & 220 & & 150 & 220 & & 150 & 220 & & MHz \\
\hline \multicolumn{13}{|l|}{SWITCHING PERFORMANCE \({ }^{1}\)} \\
\hline Conversion Rate & Full & VI & dc & & 25.6 & dc & & 25.6 & dc & & 25.6 & Msps \\
\hline Aperture Delay ( \(\mathrm{t}_{\mathrm{A}}\) ) & Full & IV & 1 & 3 & 5 & 1 & 3 & 5 & 1 & 3 & 5 & \\
\hline Aperture Uncertainty (jitter) & Full & IV & & 4 & 8 & & 4 & 8 & & 4 & 8 & ps, rms \\
\hline Output Delay ( \(\mathrm{t}_{\text {OD }}\) ) & Full & IV & 9 & 13 & 17 & 9 & 13 & 17 & 9 & 13 & 17 & \\
\hline Data Ready Delay ( \(\mathrm{t}_{\mathrm{DR}}\) ) & Full & IV & 3.5 & 7.5 & 10.5 & 3.5 & 7.5 & 10.5 & 3.5 & 7.5 & 10.5 & ns \\
\hline Output Time Skew & Full & IV & & 1 & 2 & & 1 & 2 & & 1 & 2 & ns \\
\hline \multicolumn{13}{|l|}{ENCODE INPUT} \\
\hline Logic " 1 " Voltage & Full & IV & -1.1 & & & \(-1.1\) & & & -1.1 & & & V \\
\hline Logic "0" Voltage & Full & IV & & & \(-1.5\) & & & -1.5 & & & \(-1.5\) & V \\
\hline Logic " 1 " Current & Full & VI & & 150 & 300 & & 150 & 300 & & 150 & 300 & \(\mu \mathrm{A}\) \\
\hline Logic "0" Current & Full & VI & & 150 & 300 & & 150 & 300 & & 150 & 300 & \(\mu \mathrm{A}\) \\
\hline Input Capacitance & \(+25^{\circ} \mathrm{C}\) & V & & 10 & & & 10 & & & 10 & & pF \\
\hline Pulse Width (High) & \(+25^{\circ} \mathrm{C}\) & IV & 10 & & & 10 & & & 10 & & & ns \\
\hline Pulse Width (Low) & \(+25^{\circ} \mathrm{C}\) & IV & 10 & & & 10 & & & 10 & & & ns \\
\hline \multicolumn{13}{|l|}{DYNAMIC PERFORMANCE} \\
\hline Transient Response & \(+25^{\circ} \mathrm{C}\) & IV & & 12 & 27 & & 12 & 27 & & 12 & 27 & ns \\
\hline Overvoltage Recovery Time & \(+25^{\circ} \mathrm{C}\) & IV & & & 37 & & 25 & 37 & & 25 & 37 & ns \\
\hline Harmonic Distortion & & & & & & & & & & & & \\
\hline Analog Input @ 1.2 MHz & \(+25^{\circ} \mathrm{C}\) & I & 70 & 80 & & 75 & 82 & & 75 & 82 & & dBc \\
\hline @ 1.2 MHz & Full & VI & 67 & & & 70 & & & 70 & & & dBc \\
\hline @ 4.3 MHz & \(+25^{\circ} \mathrm{C}\) & V & & 76 & & & 77 & & & 77 & & dBc \\
\hline @ 9.6 MHz & \(+25^{\circ} \mathrm{C}\) & I & 68 & 75 & & 72 & 76 & & 72 & 76 & & dBc \\
\hline @ 9.6 MHz & Full & VI & 64 & & & 68 & & & 64 & & & dBc \\
\hline @ 12.1 MHz & \(+25^{\circ} \mathrm{C}\) & V & & 72 & & & 74 & & & 74 & & dBc \\
\hline Signal-to-Noise Ratio \({ }^{2}\) & & & & & & & & & & & & \\
\hline Analog Input @ 1.2 MHz & \(+25^{\circ} \mathrm{C}\) & I & \[
63
\] & 66 & & & 67 & & & 67 & & dB \\
\hline @ 1.2 MHz & Full & VI & 61 & & & 63 & & & 61 & & & dB \\
\hline @ 4.3 MHz & \(+25^{\circ} \mathrm{C}\) & V & & 64 & & & 65 & & & 65 & & dB \\
\hline @ 9.6 MiHz & \(+25^{\circ} \mathrm{C}\) & I & 62 & 64 & & & 64 & & 62 & 64 & & dB \\
\hline @ 9.6 MHz & Full & VI & 60 & & & 61 & & & 58 & & & dB \\
\hline @ 12.1 MHz & \(+25^{\circ} \mathrm{C}\) & V & & 64 & & & 64 & & & 64 & & dB \\
\hline Two-Tone Intermodulation Distortion Rejection \({ }^{3}\) & \(+25^{\circ} \mathrm{C}\) & V & & 66 & & & 68 & & & 68 & & dBc \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Parameter (Conditions)} & \multirow[b]{2}{*}{Temp} & \multirow[t]{2}{*}{Test Level} & \multicolumn{3}{|c|}{AD9032AD/AZ} & \multicolumn{3}{|c|}{AD9032BD/BZ} & \multicolumn{3}{|r|}{AD9032TD/TZ} & \multirow[b]{2}{*}{Units} \\
\hline & & & Min & Typ & Max & Min & Typ & Max & Min & Typ & Max & \\
\hline \begin{tabular}{l}
DIGITAL OUTPUTS (10K ECL) \\
Logic "1" Voltage \\
Logic "0" Voltage \\
Output Coding
\end{tabular} & Full Full & \[
\begin{array}{|l}
\text { VI } \\
\text { VI }
\end{array}
\] & \[
\begin{array}{r}
-1.1 \\
\quad 2 \mathrm{~s}
\end{array}
\] & mp & \[
\begin{aligned}
& -1.5 \\
& \text { ent }
\end{aligned}
\] & \[
\begin{array}{r}
-1.1 \\
2 \mathrm{~s}
\end{array}
\] & Comp & \[
\begin{aligned}
& -1.5 \\
& \text { ent }
\end{aligned}
\] & \[
-1.1
\] & Comp & \[
\begin{aligned}
& -1.5 \\
& \text { ent }
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{~V}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
POWER SUPPLY \\
\(+V_{\text {S }}\) Supply Voltage \\
\(+V_{\text {S }}\) Supply Current \\
- \(\mathrm{V}_{\text {S }}\) Supply Voltage \\
- V Supply Current \\
Power Dissipation \\
Power Supply \\
Rejection Ratio (PSRR) \({ }^{4}\)
\end{tabular} & \begin{tabular}{l}
Full \\
Full \\
Full \\
Full \\
Full \\
Full
\end{tabular} & \[
\begin{aligned}
& \text { VI } \\
& \text { VI } \\
& \text { VI } \\
& \text { VI } \\
& \text { VI } \\
& \text { VI }
\end{aligned}
\] & 4.75
-5.45 & \begin{tabular}{l}
5.0 \\
133 \\
\(-5.2\) \\
610 \\
3.8 \\
4.0
\end{tabular} & \[
\begin{aligned}
& 5.25 \\
& 160 \\
& -4.95 \\
& 672 \\
& 4.5 \\
& \\
& 10
\end{aligned}
\] & 4.75
-5.45 & \[
\begin{aligned}
& 5.0 \\
& 133 \\
& -5.2 \\
& 610 \\
& 3.8 \\
& \\
& 4.0
\end{aligned}
\] & \[
\begin{aligned}
& 5.25 \\
& 160 \\
& -4.95 \\
& 672 \\
& 4.5 \\
& \\
& 10
\end{aligned}
\] & 4.75
-5.45 & \[
\begin{aligned}
& 5.0 \\
& 133 \\
& -5.2 \\
& 610 \\
& 3.8 \\
& \\
& 4.0
\end{aligned}
\] & \[
\begin{aligned}
& 5.25 \\
& 160 \\
& -4.95 \\
& 672 \\
& 4.5 \\
& 10 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
mA \\
mA \\
mA \\
mA \\
W \\
\(\mathrm{mV} / \mathrm{V}\)
\end{tabular} \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Outputs terminated through \(510 \Omega\) to \(-5.2 \mathrm{~V} ; \mathrm{C}_{\mathrm{L}}<4 \mathrm{pF}\). Typical values are valid for \(+25^{\circ} \mathrm{C}\) ambient.
\({ }^{2}\) RMS signal to rms noise with analog input signal 1 dB below full scale at specified frequency.
\({ }^{3}\) Intermodulation measured with analog input frequencies of 9.3 MHz and 9.6 MHz at 7 dB below full scale.
\({ }^{4}\) PSRR is sensitivity of offset error to power supply variations within the \(5 \%\) limits shown.
Specifications subject to change without notice.

\section*{ABSOLUTE MAXIMUM RATINGS \({ }^{1}\)}


Analog Input . . . . . . . . . . . . . . . . . . . . . . . \(-V_{\text {s }}\) to \(+V_{\text {s }}\) Digital Inputs . . . . . . . . . . . . . . . . . . . . . . . . \(-V_{\text {S }}\) to 0 V Digital Output Current . . . . . . . . . . . . . . . . . . . . . . 20 mA
Operating Temperature Range
AD9032AD/BD/AZ/BZ . . . . . . . . . . . . . . \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
AD9032TD/TZ . . . . . . . . . . . . . . . . . \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
Maximum Junction Temperature \({ }^{2}\). . . . . . . . . . . . . . \(+175^{\circ} \mathrm{C}\)
Lead Temperature (Soldering, 10 seconds) . . . . . . . \(+300^{\circ} \mathrm{C}\)
Storage Temperature Range . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)

\section*{NOTES}
\({ }^{1}\) Absolute maximum ratings are limiting values to be applied individually, and beyond which the serviceability of the circuit may be impaired. Functional operability is not necessarily implied. Exposure to absolute maximum rating conditions for an extended period of time may affect device reliability.
\({ }^{2}\) Typical thermal impedances: \(\theta_{\mathrm{CA}}=13^{\circ} \mathrm{C} / \mathrm{W} ; \mathrm{T}_{\mathrm{J}}-\mathrm{T}_{\mathrm{C}}=10^{\circ} \mathrm{C}\) max (worst case die junction temperature rise). See Thermal Management section.

\section*{EXPLANATION OF TEST LEVELS}

Test Level
I - 100\% production tested.
II - \(100 \%\) production tested at \(+25^{\circ} \mathrm{C}\), and sample tested at specified temperatures. AC testing done on sample basis.
III - Sample tested only.
IV - Parameter is guaranteed by design and characterization testing.
V - Parameter is a typical value only.
VI - All devices are \(100 \%\) production tested at \(+25^{\circ} \mathrm{C}\). Devices are \(100 \%\) production tested at temperature extremes for extended temperature devices; sample tested at temperature extremes for commercial/industrial devices.

ORDERING GUIDE
\begin{tabular}{|c|c|c|c|}
\hline Model & Temperature Range & Package Description & Package Option \({ }^{1}\) \\
\hline AD9032AD & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 40-Pin Ceramic DIP & DH-40A \\
\hline AD9032AZ \({ }^{2}\) & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 40-Pin Ceramic Leaded Chip Carrier & Z-40 \\
\hline AD9032BD & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 40-Pin Ceramic DIP & DH-40A \\
\hline AD9032BZ \({ }^{2}\) & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 40-Pin Ceramic Leaded Chip Carrier & Z-40 \\
\hline AD9032TD & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 40-Pin Ceramic DIP & DH-40A \\
\hline AD9032TZ \({ }^{2}\) & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 40-Pin Ceramic Leaded Chip Carrier & Z-40 \\
\hline AD9034/PWB & \multicolumn{2}{|l|}{\multirow[t]{2}{*}{Printed Circuit Board (only) of Evaluation Circuit Complete Evaluation Board, Assembled and Tested (Order AD9032 DIP separately)}} & \\
\hline AD9034/PCB & & & \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) For outline information see Package Information section.
\({ }^{2}\) Ceramic leaded chip carrier packages are tested and shipped with unformed leads. Consult the factory for availability.

\section*{AD9032}

\section*{DEFINITIONS OF SPECIFICATIONS}

\section*{Analog Bandwidth}

The analog input frequency at which the spectral power of the fundamental frequency (as determined by FFT analysis) is reduced by 3 dB .
Aperture Delay ( \(\mathrm{t}_{\mathrm{A}}\) )
The delay between the rising edge of the ENCODE command and the instant at which the analog input is sampled.
Aperture Uncertainty (Jitter)
The sample-to-sample variation in aperture delay.
Data Ready Delay ( \(t_{\text {DR }}\) )
The delay between the \(50 \%\) point of the change in output data and the \(50 \%\) point of the rising edge of DATA READY.
Differential Nonlinearity (DNL)
The deviation of any code width from an ideal 1 LSB step, as determined by a histogram.

\section*{Harmonic Distortion}

The rms value of the fundamental divided by the rms value of the worst harmonic.
Integral Nonlinearity (INL)
The deviation of the transfer function from a reference line measured in fractions of 1 LSB using a "best straight line" determined by a least square curve fit, as determined by a histogram.
Output Delay ( \(t_{\text {OD }}\) )
The delay between the \(50 \%\) point of the rising edge of the ENCODE command and the \(50 \%\) point of the next change in output data.

Output Time Skew
Bit-to-bit time variations among \(D_{0}\) to \(D_{11}\) outputs. Time skew includes HIGH-to-LOW and LOW-to-HIGH transitions of the digital output bits.

\section*{Overvoltage Recovery Time}

The amount of time required for the converter to recover to 12-bit accuracy after an analog input signal \(150 \%\) of full scale is reduced to the midscale of the converter.

\section*{Power Supply Rejection Ratio}

The ratio of a change in power supply voltage which results in a change in input offset voltage.

\section*{Pulse Width (High and Low)}

Rated performance of the ADC is assured when stated restrictions on ENCODE pulse width shown in Specifications table are observed.

\section*{Signal-to-Noise Ratio (SNR)}

The ratio of the rms signal amplitude to the rms value of "noise," which is defined as the sum of all other spectral components, including harmonics but excluding dc, with an analog input signal 1 dB below full scale.

\section*{Spurious Free Dynamic Range (SFDR)}

The rms value of the fundamental divided by the rms value of the highest spurious signal. This is generally specified as a function of input signal level.

\section*{Transient Response}

The time required for the converter to achieve 12 -bit accuracy when a full-scale step function is applied to the analog input.
Two-Tone Intermodulation Distortion (IMD) Rejection The ratio of the power of either of two input signals to the power of the strongest third-order IMD signal.


\section*{PIN DESCRIPTIONS}
\begin{tabular}{|c|c|c|}
\hline Pin & Name & Description \\
\hline 1 & \begin{tabular}{l}
GAIN \\
ADJUST
\end{tabular} & Can be used to null out initial gain error of ADC. Normally open. \\
\hline 2 & \begin{tabular}{l}
OFFSET \\
ADJUST
\end{tabular} & Can be used to null out initial offset error of ADC. Normally open. \\
\hline \[
\begin{aligned}
& 3,5,6, \\
& 14,21, \\
& 22,35,40
\end{aligned}
\] & GROUND & All ground pins should be connected together and to low-impedance ground plane near AD9034. \\
\hline 4 & ANALOG INPUT & Analog input to ADC, \(\pm 1.024 \mathrm{~V}\) input range; \(100 \Omega\) input resistance; 7 pF input capacitance. \\
\hline \[
\begin{aligned}
& 7,8,9,15 \\
& 16,36,37
\end{aligned}
\] & DNC & Do not connect. Internal test points. \\
\hline 10 & OVERFLOW & ECL-compatible output; normally low. High when analog input \(>+\) FS. \\
\hline 11 & DATA READY & ECL-compatible output. Rising edge of signal suitable, for externally latching \(D_{0}-D_{11}\). \\
\hline \[
\begin{aligned}
& 12,17 \\
& 20,38
\end{aligned}
\] & \(-\mathrm{V}_{\mathrm{s}}\) & -5.2 V supply voltage. \\
\hline 13, 39 & \(+\mathrm{V}_{\mathrm{S}}\) & +5.0 V supply voltage. \\
\hline 18 & ENCODE & Differential ECL convert command. \\
\hline 19 & ENCODE & Sampling occurs on rising edge; no internal terminations. \\
\hline 23-34 & \(\mathrm{D}_{0}-\mathrm{D}_{11}\) & ECL-compatible digital outputs; 2s complement coding. \\
\hline
\end{tabular}

\section*{PIN DESIGNATIONS}


\section*{THEORY OF OPERATION}

The AD9032 is a digitally corrected subranging analog-to-digital converter (ADC) optimized for fast sampling rates and dynamic range. Refer to the block diagram on the first page. The AD9032 is a vertically integrated structure consisting of a track-and-hold (T/H) amplifier, a combined flash ADC and digital-toanalog (DAC), a summation amplifier, digital error correction logic, and timing circuits. Reference circuits to generate stable DC voltages and currents that maintain the static accuracy of the device are also included, but are not shown on the block diagram.

Internally, the monolithic T/H (AD9101) provides fast settling and acquisition times while minimizing distortion introduced by the sampling process. The unique design of the sampling bridge allows accurate sampling of high slew rate signals with negligible distortion. The effects of jitter and other aperture errors have been reduced to provide dynamic performance previously unavailable in monolithic and discrete designs.

At the output of the \(\mathrm{T} / \mathrm{H}\) amplifier, the analog input is converted by the first (5-bit) ADC. This 5 -bit representation of the input value is stored in the digital error correction logic. It is also converted back to an analog signal by the 14-bit-accurate DAC on the same chip with the ADC. The 32 DAC current sources are steered directly by the outputs of the 32 input comparators on the 5 -bit ADC. This minimizes propagation delay through the DAC, and allows the summation of the DAC signal and the held output of the \(\mathrm{T} / \mathrm{H}\) to settle quickly. The hold time of the T/H is optimized to allow sufficient settling time without sacrificing the acquisition time necessary to acquire the next sample.
The residue signal, representing the difference between the 5-bit conversion (DAC output) and the input signal held by the T/H, is amplified by the summation amplifier. During the tracking period of the \(\mathrm{T} / \mathrm{H}\), this residue signal can be much larger than the input range of the 8 -bit ADC and would saturate the output stage of a normal amplifier. To protect the ADC and maintain fast settling times under all conditions, the summation amplifier is a custom design with clamping circuits that prevent saturation, limit the output voltage, and preserve settling time.
The 8 -bit flash ADC determines the 7 least significant bits (LSBs) of the 12 -bit conversion and generates a correction bit for any small errors created by inaccuracies in the first 5-bit conversion. This 8 -bit signal and the 5 -bit quantization are combined to obtain a 12 -bit-accurate representation of the analog input voltage.

\section*{AD9032}

\section*{USING THE AD9032}

\section*{Layout Information}

Preserving the accuracy and dynamic performance of the AD9032 requires that designers pay special attention to the layout of the printed circuit board. Signal paths should be impedance matched and properly terminated at or near the package connections. Analog signal paths should be isolated from digital signal paths. Capacitive and inductive coupling of digital signals into analog signal sections can degrade the overall performance of the \(\mathrm{A} / \mathrm{D}\) converter.

\section*{Analog Input}

The analog input pin of the AD9032 is terminated with a \(100 \Omega\) load. The analog input range of the AD9032 is factory trimmed for a \(\pm 1.024 \mathrm{~V}\) input for compatibility with the AD9034. The signal presented to the monolithic \(\mathrm{T} / \mathrm{H}\) is divided in half to optimize dynamic performance.
When the amplitude, bandwidth, or dc level of the analog input requires external signal conditioning, the selection of the input amplifier is of particular concern. The noise and distortion of the amplifier must be taken into account to preserve the dynamic range of the AD9032. The AD9617 wideband, current feedback amplifier is an excellent choice for most applications.

\section*{Timing}

Internal timing for the AD9032 is trimmed at the factory to simplify use. Care should be taken to ensure that the encode command to the AD9032 is free from jitter that can degrade dynamic performance. Differential ECL inputs to the AD9032 can be derived from a single-ended source using a fast comparator such as the AD96685. The encode source should be located and terminated as close to the AD9032 as possible.
The ECL-compatible digital outputs are latched to provide valid data for the entire conversion period (less the transition region of latch). This data should be latched into external ECL registers located near the AD9032. External termination resistors are required ( \(510 \Omega\) recommended). The data are latched with either the encode command or the data ready signal provided on the AD9032. The rising edge of the data ready signal occurs typically 7.5 ns after the data changes.

\section*{Gain and Offset Adjustment}

Gain and offset pins are normally not connected. Rated performance is guaranteed without any external connection to these pins. In most applications, wide variations in input signal range and offset can be accommodated using external amplifiers. However, in those applications where a vernier adjustment is required (such as nulling out factory trim limits), the gain and offset pins will provide sufficient adjustment range.
Both inputs offer a \(20 \mathrm{k} \Omega\) input resistance that can be driven from a voltage source (DAC, amplifier) or the center tap of a potentiometer. The offset pin provides a \(195 \mathrm{mV} / \mathrm{V}\) sensitivity to input offset, while the gain pin offers \(120 \mathrm{mV} / \mathrm{V}\) adjustment of the full-scale input range of the ADC. The adjustment range for offset is limited to 10 mV and for gain is 20 mV without introducing potential dynamic errors or restricting the operating temperature range of the part.

\section*{Power Supplies}

The unique design of the AD9032 provides excellent dynamic performance without a need for high voltage power supplies. Two supplies ( +5 V and -5.2 V ) are all that are required to achieve rated performance. Careful layout and decoupling of power supplies used in conjunction with a low impedance analog ground plane will reduce supply-related noise components.
Separate analog and digital supplies are not required. In applications with only limited analog supply current, a separate digital supply source can be used for the -5.2 V supply on Pin 20. This supply typically requires \(310 \mathrm{~mA}(330 \mathrm{~mA}\) max) and may be shared with other ECL logic devices when isolated with bypass capacitors and/or ferrite bead inductors (Fair-Rite Products Corporation part \# 2743001111, Wallkill, NY). Each power supply pin should be capacitively decoupled to the ground plane through a good high frequency ceramic capacitor \((0.1 \mu \mathrm{~F})\) and a single large value capacitor (tantalum \(10 \mu \mathrm{~F}\) ).
For optimum performance, "clean" linear supplies ensure that switching noise on the supplies does not introduce distortion products during the encoding process. Recognizing, however, that switching power supplies may be required in powersensitive applications, decoupling recommendations outlined above are critically important for using switching supplies effectively. Elsewhere in this data sheet, a graph shows the PSRR of the AD9032 as a function of the ripple frequency present on the AD9032 supplies. Clearly, if they must be used, switching power supplies with the lowest possible frequency should be selected.

\section*{Thermal Management}

The AD9032 design minimizes power dissipation; however, the ADC does typically require \(3.8 \mathrm{~W}(4.5 \mathrm{~W}\) max) to operate. To ensure long life and reliable operation, the maximum junction temperature in the AD 9032 must be limited to \(+175^{\circ} \mathrm{C}\).
Within the hybrid, the hottest discrete die has a case to junction temperature rise of \(10^{\circ} \mathrm{C}\) (max). Therefore, the case temperature of the AD9032 should not exceed \(+165^{\circ} \mathrm{C}\) under worst case operating conditions. Without airflow, the \(\theta_{\mathrm{CA}}\) of the hybrid package is \(13^{\circ} \mathrm{C} / \mathrm{W}\). Assuming maximum power dissipation, this causes a \(57^{\circ} \mathrm{C}\) rise in case temperature over the ambient air temperature. The maximum still air temperature, therefore, is equal to \(+108^{\circ} \mathrm{C}\).
Rated performance of the AD9032 is guaranteed for case operating temperatures of \(+85^{\circ} \mathrm{C}(\mathrm{AD} 9032 \mathrm{~A} / \mathrm{B})\) and \(+125^{\circ} \mathrm{C}\) (AD9032T). This equates to a maximum operating ambient temperature of \(+28^{\circ} \mathrm{C}\) and \(+68^{\circ} \mathrm{C}\), respectively, in still air. In most applications, airflow is recommended. The following improvements in the thermal characteristics of the system assume that the AD9032 is soldered to a PC board.
The \(\theta_{\text {CA }}\) of the hybrid is reduced to \(5^{\circ} \mathrm{C} / \mathrm{W}\) with 500 LFPM airflow. This will extend the rated performance to ambient operating ranges of \(+63^{\circ} \mathrm{C}\) for the \(\dot{A} D 9032 \dot{A} / \bar{B}\) and \(+103^{\circ} \mathrm{C}\) for the AD9032T. The addition of a heat sink (Thermalloy \#6087B, Dallas, Texas; phone 214-243-0839) will further improve the thermal transfer of the hybrid to \(3^{\circ} \mathrm{C} / \mathrm{W}\) (@ 500 LFPM). Using a heat sink with airflow, the total case to ambient temperature rise is only \(13^{\circ} \mathrm{C}\), which results in a maximum ambient environment of \(+72^{\circ} \mathrm{C}(\mathrm{AD} 9032 \mathrm{~A} / \mathrm{B})\) and \(+112^{\circ} \mathrm{C}(\mathrm{AD} 9032 \mathrm{~T})\).


AD9032 A/D Converter FFT


AD9032 Harmonic Distortion vs. Analog Input


AD9032 PSRR vs. Supply Ripple Frequency


AD9032 AVD Converter FFT


AD9032 SNR vs. Analog Input


Equivalent Analog Input Circuit


Equivalent Encode Input Circuit


Equivalent Digital Output Circuit

10-Bit 40 MSPS AD Converter

\section*{FEATURES}

Low Power: 940 mW
53 dB SNR @ \(10 \mathrm{MHz} \mathrm{A}_{\text {IN }}\)
On-Chip T/H, Reference
CMOS-Compatible
2 V p-p Analog Input
Fully Characterized Dynamic Performance

\section*{APPLICATIONS}

Ultrasound Medical Imaging
Digital Oscilloscopes
Professional Video
Digital Communications
Advanced Television (MUSE Decoders) Instrumentation

\section*{GENERAL DESCRIPTION}

The AD9040A is a complete 10 -bit monolithic sampling analog-to-digital converter (ADC) with on-board track-and-hold and reference. The unit is designed for low cost, high performance applications and requires only an encode signal to achieve 40 Msps sample rates with 10 -bit resolution.
Digital inputs and outputs are CMOS compatible; the analog input requires a signal of 2 V p-p amplitude. The two-step architecture used in the AD9040A is optimized to provide the best dynamic performance available while maintaining low power requirements of only 940 mW typically; maximum dissipation is 1.1 watt at 40 Msps .

The signal-to-noise ratio (SNR), including harmonics, is 53 dB , or 8.5 ENOB, when sampling an analog input of 10.3 MHz at 40 Msps . Competitive devices perform at less than 7.5 ENOB and require external references and larger input signals.
The AD9040A A/D converter is available as either a 28 -pin plastic DIP or a 28 -pin SOIC. The two models operate over a commercial temperature range of \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\). Contact the factory regarding availability of ceramic military temperature range devices.

FUNCTIONAL BLOCK DIAGRAM


\section*{PRODUCT HIGHLIGHTS}
1. CMOS compatible logic for direct interface to ASICs.
2. On-board \(\mathrm{T} / \mathrm{H}\) provides excellent high frequency performance on analog inputs, critical for communications and medical imaging applications.
3. High input impedance and 2 volt p -p input range reduce need for external amplifiers.
4. Easy to use; no cumbersome external voltage references required, allowing denser packing of ADCs for multichannel applications.
5. Available in 28-lead plastic DIP and SOIC packages.
6. Evaluation board includes AD9040AJR, reconstruction DAC, and latches. Space is available near the analog input and digital outputs of the converter for additional circuits. Order as part number AD9040A/PCB (schematic shown in data sheet).

\section*{}
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline Parameter (Conditions) & Temp & Test Level & Min & AD9040AJN/JR Typ & Max & Units \\
\hline RESOLUTION & & & & 10 & & Bits \\
\hline \begin{tabular}{l}
DC ACCURACY \\
Differential Nonlinearity \\
Integral Nonlinearity \\
No Missing Codes Gain Error \\
Gain Tempco \({ }^{1}\)
\end{tabular} & \[
\begin{aligned}
& +25^{\circ} \mathrm{C} \\
& \text { Full } \\
& +25^{\circ} \mathrm{C} \\
& \text { Full } \\
& \text { Full } \\
& +25^{\circ} \mathrm{C} \\
& \text { Full } \\
& \text { Full }
\end{aligned}
\] & \[
\begin{aligned}
& \text { I } \\
& \text { VI } \\
& \text { I } \\
& \text { VI } \\
& \text { VI } \\
& \text { I } \\
& \text { VI }
\end{aligned}
\] & & \[
\begin{gathered}
1.0 \\
1.0 \\
\text { Guaranteed } \\
\pm 0.5 \\
\pm 70
\end{gathered}
\] & \[
\begin{aligned}
& 2.0 \\
& 2.5 \\
& 2.0 \\
& 2.5 \\
& \pm 1.5 \\
& \pm 2
\end{aligned}
\] & \begin{tabular}{l}
LSB \\
LSB \\
LSB \\
LSB \\
\% FS \\
\% FS \\
\(\mathrm{ppm} /{ }^{\circ} \mathrm{C}\)
\end{tabular} \\
\hline ANALOG INPUT Input Voltage Range Input Offset Voltage Input Bias Current Input Resistance Input Capacitance Analog Bandwidth & \[
\begin{aligned}
& +25^{\circ} \mathrm{C} \\
& +25^{\circ} \mathrm{C} \\
& \text { Full } \\
& +25^{\circ} \mathrm{C} \\
& \text { Full } \\
& +25^{\circ} \mathrm{C} \\
& +25^{\circ} \mathrm{C} \\
& +25^{\circ} \mathrm{C}
\end{aligned}
\] & \[
\begin{aligned}
& \text { V } \\
& \text { I } \\
& \text { VI } \\
& \text { I } \\
& \text { VI } \\
& \text { I } \\
& \text { V }
\end{aligned}
\] & 200 & \[
\begin{aligned}
& 2 \\
& \pm 2 \\
& 7 \\
& \\
& 350 \\
& 5 \\
& 48
\end{aligned}
\] & \[
\begin{aligned}
& \pm 25 \\
& \pm 30 \\
& 15 \\
& 25
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{V} \text { p-p } \\
& \mathrm{mV} \\
& \mathrm{mV} \\
& \mu \mathrm{~A} \\
& \mu \mathrm{~A} \\
& \mathrm{k} \Omega \\
& \mathrm{pF} \\
& \mathrm{MHz}
\end{aligned}
\] \\
\hline BANDGAP REFERENCE Output Voltage Temperature Coefficient \({ }^{1}\) & \begin{tabular}{l}
Full \\
Full
\end{tabular} & \[
\begin{aligned}
& \text { VI } \\
& \text { V }
\end{aligned}
\] & 2.4 & \[
\pm 40
\] & 2.6 & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{ppm} /{ }^{\circ} \mathrm{C}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
SWITCHING PERFORMANCE \\
Maximum Conversion Rate Minimum Conversion Rate Aperture Delay ( \(\mathrm{t}_{\mathrm{A}}\) ) Aperture Uncertainty (Jitter) Output Propagation Delay \(\left(\mathrm{t}_{\mathrm{PD}}\right)^{2}\)
\end{tabular} & \[
\begin{aligned}
& +25^{\circ} \mathrm{C} \\
& +25^{\circ} \mathrm{C} \\
& +25^{\circ} \mathrm{C} \\
& +25^{\circ} \mathrm{C} \\
& +25^{\circ} \mathrm{C} \\
& \text { Full }
\end{aligned}
\] & \begin{tabular}{l}
I \\
IV \\
V \\
V \\
I \\
IV
\end{tabular} & 40
\[
7.5
\]
\[
6
\] & \[
\begin{aligned}
& 2 \\
& 1.9 \\
& 7 \\
& 10
\end{aligned}
\] & 10
\[
12
\]
\[
14
\] & \begin{tabular}{l}
Msps \\
Msps \\
ns \\
ps, rms \\
ns \\
ns
\end{tabular} \\
\hline \begin{tabular}{l}
DYNAMIC PERFORMANCE \\
Transient Response Overvoltage Recovery Time Signal-to-Noise Ratio \({ }^{3}\)
\[
\begin{aligned}
& \mathrm{f}_{\mathrm{IN}}=2.3 \mathrm{MHz} \\
& \mathrm{f}_{\mathrm{IN}}=10.3 \mathrm{MHz}
\end{aligned}
\] \\
Signal-to-Noise Ratio \({ }^{3}\) (Without Harmonics)
\[
\begin{aligned}
& \mathrm{f}_{\mathrm{IN}}=2.3 \mathrm{MHz} \\
& \mathrm{f}_{\mathrm{IN}}=10.3 \mathrm{MHz}
\end{aligned}
\] \\
Signal-to-Noise Ratio \({ }^{3,4}\)
\[
\begin{aligned}
& \mathrm{f}_{\mathrm{IN}}=2.3 \mathrm{MHz} \\
& \mathrm{f}_{\mathrm{IN}}=10.3 \mathrm{MHz}
\end{aligned}
\] \\
Signal-to-Noise Ratio \({ }^{3,4}\) \\
(Without Harmonics)
\[
\begin{aligned}
& \mathrm{f}_{\mathrm{IN}}=2.3 \mathrm{MHz} \\
& \mathrm{f}_{\mathrm{IN}}=10.3 \mathrm{MHz}
\end{aligned}
\] \\
2nd Harmonic Distortion
\[
\begin{aligned}
& \mathrm{f}_{\mathrm{IN}}=2.3 \mathrm{MHz} \\
& \mathrm{f}_{\mathrm{IN}}=10.3 \mathrm{MHz}
\end{aligned}
\] \\
3rd Harmonic Distortion
\[
\begin{aligned}
& \mathrm{f}_{\mathrm{IN}}=2.3 \mathrm{MHz} \\
& \mathrm{f}_{\mathrm{IN}}=10.3 \mathrm{MHz}
\end{aligned}
\] \\
Two-Tone Intermodulation Distortion Rejection \({ }^{5}\) \\
Differential Phase \\
Differential Gain
\end{tabular} & \[
\begin{aligned}
& +25^{\circ} \mathrm{C} \\
& +25^{\circ} \mathrm{C} \\
& +25^{\circ} \mathrm{C} \\
& +25^{\circ} \mathrm{C} \\
& \\
& +25^{\circ} \mathrm{C} \\
& +25^{\circ} \mathrm{C} \\
& +25^{\circ} \mathrm{C} \\
& +25^{\circ} \mathrm{C} \\
& \\
& +25^{\circ} \mathrm{C} \\
& +25^{\circ} \mathrm{C} \\
& +25^{\circ} \mathrm{C} \\
& +25^{\circ} \mathrm{C} \\
& +25^{\circ} \mathrm{C} \\
& +25^{\circ} \mathrm{C} \\
& +25^{\circ} \mathrm{C} \\
& +25^{\circ} \mathrm{C} \\
& +25^{\circ} \mathrm{C}
\end{aligned}
\] & \begin{tabular}{l}
V
V \\
I \\
I \\
I \\
I \\
I \\
I \\
I
I \\
I \\
I \\
I \\
I \\
III
\end{tabular} & \begin{tabular}{l}
51
50 \\
52 \\
51 \\
52 \\
51 \\
53 \\
53 \\
56 \\
56 \\
58 \\
58
\end{tabular} & \begin{tabular}{l}
25
40 \\
54 \\
53 \\
55 \\
54 \\
56 \\
55 \\
57 \\
56 \\
67 \\
65 \\
73 \\
70 \\
62 \\
0.15 \\
0.25
\end{tabular} & \[
\begin{aligned}
& 0.5 \\
& 1.0 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
ns \\
ns \\
dB \\
dB \\
dB \\
dB \\
dB \\
dB \\
dB \\
dB \\
dBc \\
dBc \\
dBc \\
dBc \\
dBc \\
Degrees \\
\%
\end{tabular} \\
\hline
\end{tabular}

AD9040A-SPECIFICATIONS
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline Parameter (Conditions) & Temp & Test Level & Min & \[
\begin{gathered}
\text { AD9040AJN/JR } \\
\text { Typ }
\end{gathered}
\] & Max & Units \\
\hline ENCODE INPUT & & & & & & \\
\hline Logic " 1 " Voltage & Full & VI & 4.0 & & & V \\
\hline Logic "0" Voltage & Full & VI & & & 1.0 & V \\
\hline Logic " 1 " Current & Full & VI & & & \(\pm 1\) & \(\mu \mathrm{A}\) \\
\hline Logic " 0 " Current & Full & VI & & & \(\pm 1\) & \(\mu \mathrm{A}\) \\
\hline Input Capacitance & \(+25^{\circ} \mathrm{C}\) & V & & 14 & & pF \\
\hline Encode Pulse Width (High) (ter) \({ }^{6}\) & \(+25^{\circ} \mathrm{C}\) & IV & 10 & & 100 & ns \\
\hline Encode Pulse Width (Low) ( \(\left.\mathrm{t}_{\text {EL }}\right)^{6}\) & \(+25^{\circ} \mathrm{C}\) & IV & 10 & & 100 & ns \\
\hline DIGITAL OUTPUTS & & & & & & \\
\hline Logic "1" Voltage & Full & VI & 4.95 & & & V \\
\hline Logic "0" Voltage & Full & VI & & & 0.05 & V \\
\hline Output Coding & & & & Offset Binary & & \\
\hline POWER SUPPLY & & & & & & \\
\hline \(\mathrm{V}_{\mathrm{D}}\) Supply Current & Full & VI & & 13 & 20 & mA \\
\hline + \(\mathrm{V}_{\text {S }}\) Supply Current & Full & VI & & 89 & 105 & mA \\
\hline - V \({ }_{\text {S }}\) Supply Current & Full & VI & & 87 & 100 & mA \\
\hline Power Dissipation & Full & VI & & 0.94 & 1.1 & W \\
\hline \begin{tabular}{l}
Power Supply \\
Rejection Ratio (PSRR) \({ }^{7}\)
\end{tabular} & \(+25^{\circ} \mathrm{C}\) & I & & & \(\pm 15\) & \(\mathrm{mV} / \mathrm{V}\) \\
\hline
\end{tabular}

\section*{NOTES}
"'Gain Tempco" is for converter using internal reference; "Temperature Coefficient" is for bandgap reference only.
\({ }^{2}\) Output propagation delay ( \(\mathrm{t}_{\mathrm{PD}}\) ) is measured from the \(50 \%\) point of the falling edge of the encode command to the \(\mathrm{min} / \mathrm{max}\) voltage levels of the digital outputs with 10 pF maximum loads.
\({ }^{3}\) RMS signal to rms noise with analog input signal 1 dB below full scale at specified frequency.
\({ }^{4}\) ENCODE \(=32 \mathrm{Msps}\).
\({ }^{5} 3\) rd order intermodulation measured with analog input frequencies of 2.3 MHz and 2.4 MHz at 7 dB below full scale.
\({ }^{6}\) For rated performance at 40 Msps , duty cycle of encode command should be \(50 \% \pm 10 \%\).
\({ }^{7}\) Measured as the ratio of the change in offset voltage for a \(5 \%\) change in \(+V_{S}\) or \(-V_{S}\)
Specifications subject to change without notice.

\section*{EXPLANATION OF TEST LEVELS}

\section*{Test Level}

I - \(100 \%\) Production Tested.
II \(-100 \%\) production tested at \(+25^{\circ} \mathrm{C}\), and sample tested at specified temperatures. AC testing done on sample basis.
III - Sample Tested Only.
IV - Parameter is guaranteed by design and characterization testing.
V - Parameter is a typical value only.
VI - All devices are \(100 \%\) production tested at \(+25^{\circ} \mathrm{C}\). \(100 \%\) production tested at temperature extremes for military temperature devices; guaranteed by design and characterization testing for industrial devices.

\section*{ABSOLUTE MAXIMUM RATINGS \({ }^{1}\)}
\(\pm \mathrm{V}_{\mathrm{S}}\). . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . \(\pm 7\) V
V D \(_{\text {. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . }+7 \text { V }}\)
ANALOG IN . . . . . . . . . . . . . . . . . . . . . . . \(-V_{\mathrm{S}}\) to \(+\mathrm{V}_{\mathrm{S}}\)
DIGITAL INPUTS . . . . . . . . . . . . . . . . . . . . 0 V to \(+V_{s}\)
\(\mathrm{V}_{\text {REF }}\) Input . . . . . . . . . . . . . . . . . . . . . . . . . 0 V to \(+\mathrm{V}_{\mathrm{S}}\)
Digital Output Current . . . . . . . . . . . . . . . . . . . . . . 20 mA
Operating Temperature
AD9040AJN/JR
. \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\)
Storage Temperature
\(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Maximum Junction Temperature \({ }^{2}\) (JN/JR Suffixes) . . . \(+150^{\circ} \mathrm{C}\)
Lead Soldering Temp (10 sec) . . . . . . . . . . . . . . . \(+300^{\circ} \mathrm{C}\)
NOTES
\({ }^{1}\) Absolute maximum ratings are limiting values to be applied individually, and beyond which the serviceability of the circuit may be impaired. Functional operability is not necessarily implied. Exposure to absolute maximum rating conditions for an extended period of time may affect device reliability.
\({ }^{2}\) Typical thermal impedances (parts soldered to board):
N Package (Plastic DIP): \(\theta_{\mathrm{JA}}=42^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=10^{\circ} \mathrm{C} / \mathrm{W}\).
R Package (SOIC): \(\theta_{\mathrm{JA}}=47^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=10^{\circ} \mathrm{C} / \mathrm{W}\).

ORDERING GUIDE
\(\left.\begin{array}{l|l|l|l}\hline \text { Model } & \text { Temperature Range } & \text { Package Description } & \text { Package Option } \\ \hline \text { AD9040AJN } & 0^{\circ} \mathrm{C} \text { to }+70^{\circ} \mathrm{C} & \text { 28-Pin Plastic DIP } & \mathrm{N}-28 \\ \text { AD9040AJR } & 0^{\circ} \mathrm{C} \text { to }+70^{\circ} \mathrm{C} & \text { 28-Pin SOIC Package } & \text { R-28 } \\ \text { AD9040A/PWB } & \text { Printed Circuit Board (Only) of Evaluation Circuit }\end{array}\right]\)

\footnotetext{
\(\star\) For outline information see Package Information section.
}


PIN DESCRIPTIONS
\begin{tabular}{|c|c|c|}
\hline Pin No. & Name & Function \\
\hline 1, 12, 21 & \(-\mathrm{V}_{\text {S }}\) & -5 V Power Supply \\
\hline 2, 4, 11, 14, 22 & GND & Ground \\
\hline 3, 10 & \(+\mathrm{V}_{\text {S }}\) & Analog +5 V Power Supply \\
\hline 5 & \(\mathrm{V}_{\text {OUT }}\) & \begin{tabular}{l}
Internal Bandgap Voltage \\
Reference (Nominally +2.5 V )
\end{tabular} \\
\hline 6 & \(\mathrm{V}_{\text {REF }}\) & Noninverting Input to Reference Amplifier. Voltage reference for ADC is connected here. \\
\hline 7 & \(\mathrm{BP}_{\text {REF }}\) & External Connection for \((0.1 \mu \mathrm{~F})\) Reference Bypass Capacitor \\
\hline 8 & NC & No Connection Internally \\
\hline 9 & ENCODE & Encode Clock Input to ADC. Internal T/H placed in hold mode (ADC is encoding) on rising edge. \\
\hline 13 & \(\mathrm{A}_{\text {IN }}\) & Noninverting Input to \(\mathrm{T} / \mathrm{H}\) Amplifier \\
\hline 15 & OR & Out-of-Range Condition Output. Active high when analog input exceeds input range of ADC by 1 LSB ( \(<\) FS -1 LSB or \(>+\) FS +1 LSB). \\
\hline 16 & D9 (MSB) & Most Significant Bit of ADC Output; TTL/CMOS Compatible \\
\hline 17-20 & D8-D5 & Digital Output Bits of ADC; TTL/ CMOS Compatible \\
\hline 23 & \(\mathrm{V}_{\mathrm{D}}\) & Digital +5 V Power Supply \\
\hline 24-27 & D4-D1 & Digital Output Bits of ADC; TTL/CMOSL Compatible \\
\hline 28 & D0 (LSB) & Least Significant Bit of ADC Output; TTL/CMOS Compatible \\
\hline
\end{tabular}


DIE LAYOUT AND MECHANICAL INFORMATION
Die Dimensions . . . . . . . . . . . . . \(204 \times 185 \times 21( \pm 1)\) mils
Pad Dimensions . . . . . . . . . . . . . . . . . . . . . . . \(4 \times 4\) mils
Metalization . . . . . . . . . . . . . . . . . . . . . . . . . . Aluminum
Backing . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . None
Substrate Potential . . . . . . . . . . . . . . . . . . . . . . . . . . \(-V_{\text {S }}\)
Transistor Count . . . . . . . . . . . . . . . . . . . . . . . . . . 5,070
Passivation . . . . . . . . . . . . . . . . . . . . . . . . . . . Oxynitride
Die Attach (JN/JR) . . . . . . . . . . . . . . . . . . . . . . . . Epoxy
Bond Wire (JN/JR) . . . . . . . . . . . . . . . . . . . . . . . . . Gold

\section*{AD9040A}

\section*{DEFINITIONS OF SPECIFICATIONS}

\section*{Analog Bandwidth}

The analog input frequency at which the spectral power of the fundamental frequency (as determined by FFT analysis) is reduced by 3 dB .

\section*{Aperture Delay}

The delay between the rising edge of the ENCODE command and the instant at which the analog input is sampled.

\section*{Aperture Uncertainty (Jitter)}

The sample-to-sample variation in aperture delay.

\section*{Differential Gain}

The percentage of amplitude change of a small high frequency sine wave \((3.58 \mathrm{MHz})\) superimposed on a low frequency signal ( 15.734 kHz ).

\section*{Differential Nonlinearity}

The deviation of any code from an ideal 1 LSB step.

\section*{Differential Phase}

The phase change of a small high frequency sine wave ( 3.58 MHz ) superimposed on a low frequency signal ( 15.734 kHz ).

\section*{Harmonic Distortion}

The rms value of the fundamental divided by the rms value of the harmonic.

\section*{Integral Nonlinearity}

The deviation of the transfer function from a reference line measured in fractions of 1 LSB using a "best straight line" determined by a least square curve fit.

\section*{Minimum Conversion Rate}

The encode rate at which the SNR of the lowest analog signal frequency tested drops by no more than 3 dB below the guaranteed limit.

\section*{Maximum Conversion Rate}

The encode rate at which parametric testing is performed.
Output Propagation Delay
The delay between the \(50 \%\) point of the falling edge of the ENCODE command and the \(1 \mathrm{~V} / 4 \mathrm{~V}\) points of output data.

\section*{Overvoltage Recovery Time}

The amount of time required for the converter to recover to 10 -bit accuracy after an analog input signal \(150 \%\) of full scale is reduced to the full-scale range of the converter.

\section*{Power Supply Rejection Ratio (PSRR)}

The ratio of a change in input offset voltage to a change in power supply voltage.

\section*{Signal-to-Noise Ratio (SNR)}

The ratio of the rms signal amplitude to the rms value of "noise," which is defined as the sum of all other spectral components, including harmonics but excluding dc, with an analog input signal 1 dB below full scale.

Signal-to-Noise Ratio (Without Harmonics)
The ratio of the rms signal amplitude to the rms value of "noise," which is defined as the sum of all other spectral components, excluding the first eight harmonics and dc, with an ana\(\log\) input signal 1 dB below full scale.

\section*{Transient Response}

The time required for the converter to achieve 10-bit accuracy when a step function is applied to the analog input.
Two-Tone Intermodulation Distortion (IMD) Rejection
The ratio of the power of either of two input signals to the power of the strongest third-order IMD signal.


Analog Input



Bandgap Output


CMOS Output

Figure 1. Equivalent Circuits

\section*{THEORY OF OPERATION}

Refer to the block diagram.
The AD9040A employs subranging architecture and digital error correction. This combination of design techniques insures true 10-bit accuracy at the digital outputs of the converter.
At the input, the analog signal is applied to a track-and-hold (T/H) that holds the analog value which is present when the unit is strobed with an ENCODE command. The conversion process begins on the rising edge of this pulse, which should have a \(50 \%\) ( \(\pm 10 \%\) ) duty cycle. Minimum encode rate of the AD9040A is 10 Msps because of the use of three internal T/H devices.
The held analog value of the first track-and-hold is applied to a 5 -bit flash converter and a pair of internal T/Hs (shown in the block diagram as a single unit). The T/Hs pipeline the analog signal to the amplifier array through a residue ladder and switch ing circuit while the 5 -bit flash converter resolves the most significant bits (MSBs) of the held analog voltage.
When the 5 -bit flash converter has completed its cycle, its output activates 1 -of- 32 ladder switches; these, in turn, cause the correct residue signal to be applied to the error amplifier array.
The output of the error amplifier is applied to a 6-bit flash converter whose output supplies the five least significant bits (LSBs) of the digital output along with one bit of error correction for the 5 -bit main range converter.
Decode logic aligns the data from the two converters and presents the result as a 10 -bit parallel digital word. The output stage of the AD9040A is CMOS. Output data are strobed on the trailing edge of the ENCODE command.
Full-scale range of the AD9040A is determined by the reference voltage applied to the \(\mathrm{V}_{\mathrm{REF}}\) (Pin 6) input. This voltage sets the internal flash and residue ladder voltage drops; these establish the value of the LSB. Because of headroom restraints, the fullscale range cannot be increased by applying a higher-thanspecified reference voltage. Conversely, a lower reference voltage will reduce the full-scale range of the converter, but will also decrease its performance. An internal bandgap reference voltage of +2.5 V is provided to assure optimum performance over the operating temperature range.

\section*{USING THE AD9040A \\ \section*{Timing}}

The duty cycle of the encode clock for the AD9040A is critical for obtaining rated performance of the ADC. Internal pulse widths within the track-and-hold are established by the encode command pulse width; to ensure rated performance, the duty cycle should be held at \(50 \%\). Duty cycle variations of less than \(\pm 10 \%\) will cause no degradation in performance.
Operation at encode rates less than 10 Msps is not recommended. The internal track-and-hold saturates, causing erroneous conversions. This T/H saturation precludes clocking the AD9040A in burst mode. The 50\% duty cycle must be maintained even for sample rates down to 10 Msps .

The AD9040A provides latched data outputs, with \(21 / 2\) pipeline delays. Data outputs are available one propagation delay ( \(\mathrm{t}_{\mathrm{PD}}\) ) after the falling edge of the encode command (refer to AD9040A Timing Diagram). The length of the output data lines and the loads placed on them should be minimized to reduce transients within the AD9040A; these transients can detract from the converter's dynamic performance.

\section*{Voltage Reference}

A stable voltage reference is required to establish the 2-V p-p range of the AD9040A. There are two options for creating this reference. The easiest and least expensive way to implement it is to use the ( +2.5 V ) bandgap voltage reference which is internal to the ADC. Figure 2 illustrates the connections for using the internal reference. The internal reference has \(500 \mu \mathrm{~A}\) of extra drive current which can be used for other circuits.


Figure 2. AD9040A Using Internal Reference
Some applications may require greater accuracy, improved temperature performance, or adjustment of the gain (input range) of the AD9040A which cannot be obtained by using the internal reference. For these applications, an external +2.5 V reference can be used, as shown in Figure 3. The \(\mathrm{V}_{\text {REF }}\) input requires \(5 \mu \mathrm{~A}\) of drive current.


Figure 3. AD9040A Using External Reference

\section*{AD9040A}

In applications using multiple AD9040As, slaving the reference inputs to a single reference output will improve gain tracking among the ADCs, as shown in Figure 4.


Figure 4. Slaving Multiple AD9040As to a Single Internal Reference

In the specifications table, the Gain Tempco parameter under DC ACCURACY applies to the ADC when the internal reference is being used. If an external reference is used, its temperature coefficient must be taken into account to determine overall temperature performance.

The input range can be varied by adjusting the reference voltage applied to the AD9040A. By decreasing the reference voltage, the gain can be reduced approximately \(10 \%\) with no degradation in performance. Increasing the reference voltage increases the gain; but for proper operation, the reference voltage should not exceed +2.6 V .

X-AMP is a trademark of Analog Devices, Inc.

\section*{Time-Gain Control ADC}

Ultrasound and sonar systems require an increase in gain versus time. This allows the system to correct for attenuation of return pulses. Figure 5 shows the AD600/602 amplifier and the AD9040A ADC configured as a time-gain control analog-todigital converter. The control voltage ramps from -625 mV to +625 mV , permitting 40 dB of gain-control range. The voltage used for gain control can be either a linear ramp, or the output of a voltage-output DAC such as the AD7242.


Figure 5. Ultrasound/Sonar Time-Gain Control ADC Using \(X\)-AMPs \({ }^{\text {M }}\)

\section*{Transient Response}

Figure 6 illustrates the method for evaluating ADC transient performance. Two synthesizers are locked in synchronization, but tuned to frequencies which are slightly offset from a 2 -to-1 submultiple.
One synthesizer clocks a flat pulse network at a frequency of 19.9609375 MHz to provide the analog input signal; the other synthesizer output is shaped to provide a CMOS 40 MHz sampling clock. At the output of the AD9040A, output data reflects an interleaved alias of the input pulse. The repetitive sampling allows the measurement of ADC transient response as shown in performance graphs elsewhere in this data sheet.


Figure 6. AD9040A Transient Response Test

\section*{Layout Information}

Preserving the accuracy and dynamic performance of the AD9040A requires that designers pay special attention to the layout of the printed circuit board.
Analog paths should be kept as short as possible and be properly terminated to avoid reflections. The analog input and reference voltage connections should be kept away from digital signal paths; this reduces the amount of digital switching noise which is capacitively coupled into the analog section. Digital signal paths should also be kept short, and run lengths should be matched to avoid propagation delay mismatch. The AD9040A digital outputs should be buffered or latched close to the device ( \(<2 \mathrm{~cm}\) ). This prevents load transients which may feedback into the device.

In high speed circuits, layout of the ground is critical. A single, low impedance ground plane on the component side of the board is recommended. Power supplies should be capacitively coupled to the ground plane with high quality chip capacitors to reduce noise in the circuit. Multilayer boards allow designers to lay out signal traces without interrupting the ground plane, and provide low impedance ground planes. In systems with dedicated analog and digital grounds, all grounds of the AD9040A should be connected to the analog ground plane.

The power supplies of the AD9040A should be isolated from the supplies used for external devices; this reduces the amount of noise coupled into the ADC. The digital +5 volt connection of the device ( \(\mathrm{V}_{\mathrm{D}}\), Pin 23) powers the digital outputs and should be connected to the same supply as \(+V_{S}\) (Pins 3 and 10). Connecting \(\mathrm{V}_{\mathrm{D}}\) to a system digital supply may couple noise into the device. Sockets limit dynamic performance and are not recommended for use with the AD9040A.

\section*{AD9040A EVALUATION BOARD}

The evaluation board for the AD9040A (AD9040A/PCB) provides an easy and flexible method for evaluating the ADC's performance without (or prior to) developing a user-specific printed circuit board. The two-sided board includes a reconstruction DAC and digital output interface, and uses the layout and applications suggestions outlined above. It is available from Analog Devices at nominal cost.

Generous space is provided near the analog input and digital outputs to support additional signal processing components the user may wish to add. This prototyping area includes through holes with \(100-\mathrm{mil}\) centers to support a variety of component additions.

\section*{Input/Output/Supply Information}

Power supply, analog input, clock connections, and reconstructed output (RC OUTPUT) are identified by labels on the evaluation board. Operation of the evaluation board should conform to the following characteristics:

Table I. Evaluation Board Characteristics
\begin{tabular}{|c|c|c|}
\hline Parameter & Typical & Units \\
\hline \[
\begin{aligned}
& \text { Supply Current } \\
& +5 \mathrm{~V} \\
& -5.2 \mathrm{~V}
\end{aligned}
\] & \[
\begin{aligned}
& 250 \\
& 300
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{mA} \\
& \mathrm{~mA}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
\(\mathrm{A}_{\text {IN }}\) \\
Impedance Voltage Range
\end{tabular} & \[
\begin{aligned}
& 51 \\
& \pm 1.0
\end{aligned}
\] & ת V \\
\hline \begin{tabular}{l}
CLOCK \\
Impedance Frequency
\end{tabular} & \[
\begin{aligned}
& 51 \\
& 40
\end{aligned}
\] & \[
\begin{aligned}
& \Omega \\
& \mathrm{Msps}
\end{aligned}
\] \\
\hline RC OUTPUT Impedance Voltage Range & \[
\begin{aligned}
& 51 \\
& 0 \text { to }-1 \mathrm{~V}
\end{aligned}
\] & \[
\begin{aligned}
& \Omega \\
& \mathrm{V}
\end{aligned}
\] \\
\hline
\end{tabular}

\section*{Analog Input}

Analog input signals can be fed directly into the Device Under Test input ( \(\mathrm{A}_{\mathrm{IN}}\) ). The \(\mathrm{A}_{\mathrm{IN}}\) input is terminated at the device with a \(51 \Omega\) resistor.


Figure 7. AD9040A/PCB Top View

\section*{DAC Reconstruction}

The AD9040A evaluation board provides an on-board AD9721 reconstruction DAC for observing the digitized analog input signal. The AD9721 is terminated into 51 ohms to provide a 1 V p-p signal at the output (RC OUTPUT).

\section*{Output Data}

The output data bits are latched with a CMOS 74AC574 which drives a 40 -pin connector (AMP p/n 102153-9). The data and clock signals are available on the connector per the pin assignments shown on the schematic of the evaluation board. Output data are available on the falling edge of the clock.


Figure 8. AD9040A/PCB Bottom View
Table II. AD9040A Digital Coding
\begin{tabular}{|c|c|c|c|}
\hline Analog Input & Voltage Level & \begin{tabular}{l}
Out-of- \\
Range
\end{tabular} & Digital Output \\
\hline \(+1.002 \mathrm{~V}\) & \multirow[b]{2}{*}{Positive Full Scale +1 LSB Positive Full Scale} & 1 & \[
\begin{aligned}
& \text { MSB . . . LSB } \\
& 111111111
\end{aligned}
\] \\
\hline \multirow[b]{2}{*}{+1 V} & & 0 & 1111111111 \\
\hline & \(\overline{\text { Full Scale - } 1 \text { LSB }}\) & 0 & \(\overline{1111111110}\) \\
\hline \multirow[b]{2}{*}{+1/2 V} & Positive 1/2 Scale & 0 & 1100000000 \\
\hline & 1/2 Scale - 1 LSB & 0 & 1011111111 \\
\hline \multirow[t]{2}{*}{0 V} & \multirow[t]{2}{*}{Bipolar Zero} & 0 & 10000000000 \\
\hline & & 0 & 01111111111 \\
\hline \multirow{2}{*}{-1/2 V} & 1/2 Scale + 1 LSB & 0 & 0100000000 \\
\hline & Negative 1/2 Scale & 0 & 0011111111 \\
\hline \multirow{2}{*}{-1 V} & Full Scale + 1 LSB & 0 & 0000000001 \\
\hline & Negative Full Scale & 0 & 0000000000 \\
\hline -1.002 V & Negative Full Scale - 1 LSB & 1 & 0000000000 \\
\hline
\end{tabular}


Figure 9. AD9040A/PCB Schematic


Figure 10. Power Dissipation vs. Clock Rate


Figure 13. Differential Nonlinearity vs. Clock Rate


Figure 16. SNR vs. Temperature

Figure 19.


Figure 11. Harmonic Distortion and SNR vs. Analog Input


Figure 14. Transient Response


Figure 17.


Figure 20.


Figure 12. SNR vs. Clock Rate


Figure 15. Transient Response (Expanded View)


Figure 18.


Figure 21.

\section*{FEATURES}

35MSPS Encode Rate
16pF Input Capacitance
550 mW Power Dissipation
Industry-Standard Pinouts
MIL-STD-883 Compliant Versions Available
APPLICATIONS
Professional Video Systems
Special Effects Generators
Electro-Optics
Digital Radio
Electronic Warfare (ECM, ECCM, ESM)

\section*{GENERAL DESCRIPTION}

The AD9048 is an 8-bit, 35MSPS flash converter, made on a high speed bipolar process, which is an alternate source for the TDC1048 unit but offers enhancements over its predecessor. Lower power dissipation makes the AD9048 attractive for a variety of system designs.

Because of its wide bandwidth, it is an ideal choice for real-time conversion of video signals. Input bandwidth is flat with no missing codes.
Clocked latching comparators, encoding logic and output buffer registers operating at minimum rates of 35MSPS preclude a need for a sample-and-hold (S/H) or track-and-hold (T/H) in most system designs using the AD9048. All digital control inputs and outputs are TTL compatible.
Devices operating over two ambient temperature ranges and with two grades of linearity are available. Linearities of either 0.5 LSB or 0.75 LSB can be ordered for a commercial range of 0

FUNCTIONAL BLOCK DIAGRAM

to \(+70^{\circ} \mathrm{C}\), or extended case temperatures of \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\). Commercial versions are packaged in 28 -pin DIPs; extended temperature versions are available in ceramic DIP and ceramic LCC packages. Both commercial units and MIL-STD-883 units are standard products.
The AD9048 A/D converter is available in versions compliant with MIL-STD-883. Refer to the Analog Devices Military Products Databook or current AD9048/883B data sheet for detailed specifications.

PIN DESIGNATIONS

DIP


LCC


J-Leaded Ceramic


This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

\section*{ABSOLUTE MAXIMUM RATINGS \({ }^{1}\)}
\(V_{C C}\) to DGND -0.5 V dc to +7.0 V dc
AGND to DGND -0.5 V dc to +0.5 V dc
\(\mathrm{V}_{\mathrm{EE}}\) to AGND +0.5 V dc to -7.0 V dc
\(\mathrm{V}_{\mathrm{IN}}, \mathrm{V}_{\mathrm{RT}}\) or \(\mathrm{V}_{\mathrm{RB}}\) to AGND
\(\mathrm{V}_{\mathrm{RT}}\) to \(\mathrm{V}_{\mathrm{RB}} \ldots . . . . . . . . . . . . .-2.2 \mathrm{~V}\) dc to +2.2 V dc CONV, NMINV or NLINV to DGND . -0.5 V dc to +5.5 V dc Applied Output Voltage to DGND . -0.5 V dc to \(+5.5 \mathrm{~V} \mathrm{dc}^{2}\) Applied Output Current, Externally Forced

Output Short-Circuit Duration . . . . . . . . . . . . . 1.0sec \({ }^{5}\)
Operating Temperature Range (Ambient)
AD9048JJ/KJ/JQ/KQ . . . . . . . . . . . . . . . 0 to \(+70^{\circ} \mathrm{C}\)
AD9048SE/SQ/TE/TQ . . . . . . . . . . \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
Maximum Junction Temperature (Plastic) ......... . \(+150^{\circ} \mathrm{C}^{6}\)
Maximum Junction Temperature (Hermetic) . . . . . \(+175^{\circ}{ }^{\circ}{ }^{6}\)
Lead Temperature (Soldering, 10 sec ) . . . . . . . . . \(+300^{\circ} \mathrm{C}\)
Storage Temperature Range . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)

ELECTRICAL CHARACTERISTICS \(N_{C C}=+5.0 V_{;} v_{E}=-5.2 v_{\text {; }}\) Differential Reference Voltage \(=2.0 V_{\text {, unless othenwise noted) }}\)

\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Parameter (Conditions)} & \multirow[b]{2}{*}{Temp} & \multirow[b]{2}{*}{Test Level} & \multicolumn{3}{|c|}{AD9048JJ/JQ} & \multicolumn{3}{|r|}{AD9048KJ/KQ} & \multicolumn{3}{|c|}{AD9048SE/SQ} & \multicolumn{3}{|l|}{AD9048TE/TQ} & \multirow[t]{2}{*}{Units} \\
\hline & & & Min & Typ & Max & Min & Typ & Max & Min & Typ & Max & Min & Typ & Max & \\
\hline \multicolumn{16}{|l|}{ACLINEARITY} \\
\hline In-Band Harmonics & & & & & & & & & & & & & & & \\
\hline dc to \(2.438 \mathrm{MHz}^{15}\) & \(+25^{\circ} \mathrm{C}\) & I & & 50 & & 49 & 55 & & 47 & 50 & & 49 & 55 & & dBc \\
\hline dc to \(9.35 \mathrm{MHz}{ }^{16}\) & \(+25^{\circ} \mathrm{C}\) & V & & 48 & & & 48 & & & 48 & & & 48 & & dBc \\
\hline Signal-to-Noise Ratio (SNR) \({ }^{15}\) & & & & & & & & & & & & & & & \\
\hline 1.248 MHz Input Frequency \({ }^{17}\) & \(+25^{\circ} \mathrm{C}\) & I & 43.5 & 44 & & 45 & 46 & & 43.5 & 44 & & 45 & 46 & & dB \\
\hline 2.438 MHz Input Frequency \({ }^{17}\) & \(+25^{\circ} \mathrm{C}\) & I & 43 & 44 & & 44 & 46 & & 43 & 44 & & 44 & 46 & & dB \\
\hline 1.248 MHz Input Frequency \({ }^{18}\) & \(+25^{\circ} \mathrm{C}\) & I & 52.5 & 53 & & 54 & 55 & & 52.5 & 53 & & 54 & 55 & & dB \\
\hline 2.438 MHz Input Frequency \({ }^{18}\) & \(+25^{\circ} \mathrm{C}\) & I & 52 & 53 & & 53 & 55 & & 52 & 53 & & 53 & 55 & & dB \\
\hline Signal-to-Noise Ratio (SNR) \({ }^{16}\) & & & & & & & & & & & & & & & \\
\hline 1.248 MHz Input Frequency \({ }^{17}\) & \(+25^{\circ} \mathrm{C}\) & I & 43.5 & 44 & & 45 & 46 & & 43.5 & 44 & & 45 & 46 & & dB \\
\hline 9.35MHz Input Frequency \({ }^{17}\) & \(+25^{\circ} \mathrm{C}\) & V & & 40.5 & & & 40.5 & & & 40.5 & & & 40.5 & & dB \\
\hline Noise Power Ratio(NPR) \({ }^{19}\) & \(+25^{\circ} \mathrm{C}\) & III & 36.5 & 39 & & 36.5 & 39 & & 36.5 & 39 & & 36.5 & 39 & & dB \\
\hline Differential Phase \({ }^{20}\) & \(+25^{\circ} \mathrm{C}\) & III & & & 1 & & & 1 & & & 1 & & & 1 & Degree \\
\hline Differential Gain \({ }^{20}\) & \(+25^{\circ} \mathrm{C}\) & III & & & 2 & & & 2 & & & 2 & & & 2 & \% \\
\hline \multicolumn{16}{|l|}{DIGITAL OUTPUTS} \\
\hline Logic " 1 " Voltage & Full & VI & 2.4 & & & 2.4 & & & 2.4 & & & 2.4 & & & V \\
\hline Logic " 0 " Voltage & Full & VI & & & 0.5 & & & 0.5 & & & 0.5 & & & 0.5 & V \\
\hline Short Circuit Current \({ }^{\text {s }}\) & Full & VI & & & 30 & & & 30 & & & 30 & & & 30 & mA \\
\hline \multicolumn{16}{|l|}{POWER SUPPLY} \\
\hline \multirow[t]{2}{*}{Positive Supply Current} & \(+25^{\circ} \mathrm{C}\) & I & & 34 & 46 & & 34 & 46 & & 34 & 46 & & 34 & 46 & mA \\
\hline & Full & VI & & & 48 & & & 48 & & & 48 & & & 48 & mA \\
\hline \multirow[t]{2}{*}{Negative Supply Current} & \(+25^{\circ} \mathrm{C}\) & I & & 90 & 110 & & 90 & 110 & & 90 & 110 & & 90 & 110 & mA \\
\hline & Full & VI & & & 120 & & & 120 & & & 120 & & & 120 & mA \\
\hline Nominal Power Dissipation & \(+25^{\circ} \mathrm{C}\) & V & & 550 & & & 550 & & & 550 & & & 550 & & mW \\
\hline Reference Ladder Dissipation & \(+25^{\circ} \mathrm{C}\) & V & & 45 & & & 45 & & & 45 & & & 45 & & mW \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Maximum ratings are limiting values, to be applied individually, and beyond which the serviceability of the device may be impaired. Functional operation under any of these conditions is not necessarily implied. Exposure to absolute maximum rating conditions for extended periods of time may affect device reliability.
\({ }^{2}\) Applied voltage must be current-limited to specified range.
\({ }^{3}\) Forcing voltage must be limited to specified range.
\({ }^{4}\) Current is specified as negative when flowing into the device.
'Output High; one pin to ground; one second duration.
\({ }^{6}\) Typical thermal impedances (no air flow) are as follows:
Ceramic DIP: \(\theta_{\mathrm{JA}}=49^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=15^{\circ} \mathrm{C} / \mathrm{W} \quad\) LCC: \(\theta_{\mathrm{JA}}=69^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=21^{\circ} \mathrm{C} / \mathrm{W}\) JLCC: \(\theta_{\text {JA }}=59^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=19^{\circ} \mathrm{C} / \mathrm{W}\)
To calculate junction temperature ( \(\mathrm{T}_{\mathrm{J}}\) ), use power dissipation (PD) and thermal impedance: \(\mathrm{T}_{\mathrm{J}}=\operatorname{PD}\left(\theta_{\mathrm{JA}}\right)+\mathrm{T}_{\text {AMBIENT }}=\operatorname{PD}\left(\theta_{\mathrm{JC}}\right)=+\mathrm{T}_{\text {CASE }}\)
\({ }^{7}\) Measured with \(\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}\) and CONVERT low (sampling mode).
\({ }^{8}\) Determined by beat frequency testing for no missing codes.
\({ }^{9} \mathrm{~V}_{\mathrm{RT}} \geq \mathrm{V}_{\mathrm{RB}}\) under all circumstances.
\({ }^{10}\) Outputs terminated with 40 pF and \(810 \Omega\) pull-up resistors.
\({ }^{14}\) Interval from \(50 \%\) point of leading edge CONVERT pulse to change in output data.
\({ }^{12}\) For full scale step input, 8 -bit accuracy attained in specified time.
\({ }^{13}\) Recovers to 8-bit accuracy in specified time after -3 V input overvoltage.
\({ }^{14}\) Output time skew includes high-to-low and low-to-high transitions as well as bit-to-bit time skew differences.
\({ }^{15}\) Measured at 20 MHz encode rate with analog input 1 dB below full scale.
\({ }^{16}\) Measured at 35 MHz encode rate with analog input 1 dB below full scale.
\({ }^{17}\) RMS signal to rms noise.
\({ }^{18}\) Peak signal to rms noise.
\({ }^{19} \mathrm{DC}\) to 8 MHz noise bandwidth with 1.248 MHz slot; four sigma loading; 20MHz encode.
\({ }^{20}\) Clock frequency \(=4 \times\) NTSC \(=14.32 \mathrm{MHz}\). Measured with \(40-\mathrm{IRE}\) modulated ramp.
Specifications subject to change without notice.

\section*{ORDERING GUIDE}
\begin{tabular}{l|l|l}
\hline Model & Temperature & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD9048JJ & 0 to \(+70^{\circ} \mathrm{C}\) & \(\mathrm{J}-28\) \\
AD9048KJ & 0 to \(+70^{\circ} \mathrm{C}\) & \(\mathrm{J}-28\) \\
AD9048JQ & 0 to \(+70^{\circ} \mathrm{C}\) & \(\mathrm{Q}-28\) \\
AD9048KQ & 0 to \(+70^{\circ} \mathrm{C}\) & \(\mathrm{Q}-28\) \\
AD90488E & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\mathrm{E}-28 \mathrm{~A}\) \\
AD9048TE \(^{2}\) & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\mathrm{E}-28 \mathrm{~A}\) \\
AD9048SQ \(^{2}\) & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\mathrm{Q}-28\) \\
AD9048TQ \(^{2}\) & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\mathrm{Q}-28\) \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1} \mathrm{E}=\) Leadless Ceramic ChipCarrier; \(\mathrm{J}=\mathrm{J}\)-Leaded Ceramic;
Q = Cerdip. For outline information see Package Information section.
\({ }^{2}\) For specifications, refer to Analog Devices Military Products Databook.

\section*{EXPLANATION OF TEST LEVELS}

Test Level I - \(100 \%\) production tested.
Test Level II - \(100 \%\) production tested at \(+25^{\circ} \mathrm{C}\) and sample tested at specified temperatures.
Test Level III - Sample tested only.
Test Level IV - Parameter is guaranteed by design and characterization testing.

Test Level V - Parameter is a typical value only.
Test Level VI - All devices are 100\% production tested at \(25^{\circ} \mathrm{C} .100 \%\) production tested at temperature extremes for military temperature devices; sample tested at temperature extremes for commercial/industrial devices.

\section*{FEATURES}

Low Power: \(\mathbf{3 0 0}\) mW
On-Chip T/H, Reference
Single +5 V Power Supply Operation
Selectable 5 V/3 V Outputs
Wide Dynamic Performance
APPLICATIONS
Medical Imaging
Instrumentation
Digital Communications
Professional Video

\section*{FUNCTIONAL BLOCK DIAGRAM}


\section*{GENERAL DESCRIPTION}

The AD9050 is a complete 10 -bit monolithic sampling analog-to-digital converter (ADC) with on-board track-and-hold and reference. The unit is designed for low cost, high performance applications and requires only +5 V and an encode clock to achieve 40 Msps sample rates with 10-bit resolution.
The encode clock is TTL compatible and the digital outputs are \(5 \mathrm{~V} / 3 \mathrm{~V}\), selected by the user. The two-step architecture used in the AD9050 is optimized to provide the best dynamic performance available while maintaining low power requirements.
The 2.5 V reference is included on-board, or the user can provide an external reference voltage for gain control, or matching of multiple devices. Fabricated on an advanced BiCMOS process, the AD9050 is packaged in space saving surface mount packages and will be specified over the commercial \(\left(0^{\circ} \mathrm{C}\right.\) to \(+85^{\circ} \mathrm{C}\) ) temperature range.


This is a preliminary data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.



\footnotetext{
This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.
}

\section*{AD9050-SPECIFICATIONS}
\begin{tabular}{l|l|l|l|l|l}
\hline Parameter & Temp & \begin{tabular}{c} 
Test \\
Level
\end{tabular} & Min & \begin{tabular}{c} 
AD9050JR/J \\
Typ
\end{tabular} & Max
\end{tabular}

Specifications subject to change without notice.

\section*{EXPLANATION OF TEST LEVELS}

\section*{Test Level}

I - \(100 \%\) Production Tested.
III - Sample Tested Only.
IV - Parameter is guaranteed by design and characterization testing.
V - Parameter is a typical value only.
VI - All devices are \(100 \%\) production tested at \(+25^{\circ} \mathrm{C}\). \(100 \%\) production tested at temperature extremes for military temperature devices; guaranteed by design and characterization testing for industrial devices.

\section*{ABSOLUTE MAXIMUM RATINGS}

VD, \(\mathrm{V}_{\mathrm{DD}}\). . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 7 V
ANALOG IN . . . . . . . . . . . . . . . . . . . . . . . -0.5 V to \(\mathrm{V}_{\mathrm{D}}+0.5 \mathrm{~V}\)
Digital Inputs . . . . . . . . . . . . . . . . . . . . . . . . . . . -0.5 V to \(\mathrm{V}_{\mathrm{D}}\)
\(\mathrm{V}_{\text {REF }}\) Input . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . -0.5 V to \(\mathrm{V}_{\mathrm{D}}\)
Digital Output Current . . . . . . . . . . . . . . . . . . . . . . . 20 mA
Operating Temperature
AD9050JR \(.0^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
Storage Temperature . . . . . . . . . . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)

\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD9050 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

\section*{FEATURES}

Two Matched ADCs on Single Chip 50 MSPS Conversion Speed
On-Board Voltage Reference
Low Power (<1W)
Low Input Capacitance ( 10 pF )
\(\pm 5\) V Power Supplies
Flexible Input Range

\section*{APPLICATIONS}

Quadrature Demodulation for Communications Digital Oscilloscopes

\section*{Electronic Warfare}

Radar

\section*{GENERAL DESCRIPTION}

The AD9058 combines two independent high performance 8 -bit analog-to-digital converters (ADCs) on a single monolithic IC. Combined with an optional on-board voltage reference, the AD9058 provides a cost effective alternative for systems requiring two or more ADCs.
Dynamic performance (SNR, ENOB) is optimized to provide up to 50 MSPS conversion rates. The unique architecture results in low input capacitance while maintaining high performance and low power ( \(<0.5\) watt/channel). Digital inputs and outputs are TTL compatible.
Performance has been optimized for an analog input of \(2 \mathrm{~V} p-\mathrm{p}\) ( \(\pm 1 \mathrm{~V} ; 0\) to +2 V ). Using the on-board +2 V voltage reference, the AD9058 can be set up for unipolar positive operation ( 0 to +2 V ). This internal voltage reference can drive both ADCs.
Commercial \(\left(0^{\circ} \mathrm{C}\right.\) to \(\left.+70^{\circ} \mathrm{C}\right)\) and military \(\left(-55^{\circ} \mathrm{C}\right.\) to \(\left.+125^{\circ} \mathrm{C}\right)\) temperature range parts are available. Parts are supplied in hermetic 48-pin DIP and 44-pin " J " lead packages.

FUNCTIONAL BLOCK DIAGRAM


QUADRATURE RECEIVER


\section*{AD9058 - SPECIFICATIONS}

ABSOLUTE MAXIMUM RATINGS \({ }^{1}\)

Analog Input -1.5 V to +2.5 V
\(+V_{s}\). . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . +6 V

Digital Inputs . . . . . . . . . . . . . . . . . . . . -0.5 V to \(+\mathrm{V}_{\mathrm{s}}\)
Digital Output Current . . . . . . . . . . . . . . . . . . . . . . 20 mA
Voltage Reference Current . . . . . . . . . . . . . . . . . . . . 53 mA
+ V \({ }_{\text {REF }}\). . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . + 2.5 V
- \(\mathrm{V}_{\text {REF }}\). . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . -1.5

Operating Temperature Range
AD9058JD/JJ/KD/KJ . . . . . . . . . . . . . . . . . \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) Maximum Junction Temperature \({ }^{3}\)

AD9058JD/JJ/KD/KJ . . . . . . . . . . . . . . . . . . . . \(+175^{\circ} \mathrm{C}\)
Storage Temperature Range . . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Lead Temperature (Soldering, 10 sec ) . . . . . . . . . . . \(+300^{\circ} \mathrm{C}\)

\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Parameter (Conditions)} & \multirow[b]{2}{*}{Temp} & \multirow[t]{2}{*}{Test Level} & \multicolumn{3}{|c|}{AD9058JD/JJ} & \multicolumn{3}{|c|}{AD9058KD/KJ} & \multirow[b]{2}{*}{Units} \\
\hline & & & Min & Typ & Max & Min & Typ & Max & \\
\hline RESOLUTION & & & 8 & & & 8 & & & Bits \\
\hline \multicolumn{10}{|l|}{DC ACCURACY} \\
\hline Differential Nonlinearity & \(+25^{\circ} \mathrm{C}\) & I & & 0.25 & 0.65 & & 0.25 & 0.5 & LSB \\
\hline & Full & VI & & & 0.8 & & & 0.7 & LSB \\
\hline Integral Nonlinearity & \(+25^{\circ} \mathrm{C}\) & I & & 0.5 & 1.3 & & 0.5 & 1.0 & LSB \\
\hline & Full & VI & & & 1.4 & & & 1.25 & LSB \\
\hline No Missing Codes & Full & VI & & RAN & & & RANT & & \\
\hline \multicolumn{10}{|l|}{ANALOG INPUT} \\
\hline Input Bias Current & \(+25^{\circ} \mathrm{C}\) & I & & 75 & 170 & & 75 & 170 & \(\mu \mathrm{A}\) \\
\hline & Full & VI & & & 340 & & & 340 & \(\mu \mathrm{A}\) \\
\hline Input Resistance & \(+25^{\circ} \mathrm{C}\) & I & 12 & 28 & & 12 & 28 & & \(\mathrm{k} \Omega\) \\
\hline Input Capacitance & \(+25^{\circ} \mathrm{C}\) & IV & & 10 & 15 & & 10 & 15 & pF \\
\hline Analog Bandwidth & \(+25^{\circ} \mathrm{C}\) & V & & 175 & & & 175 & & MHz \\
\hline \multicolumn{10}{|l|}{REFERENCE INPUT} \\
\hline Reference Ladder Resistance & \(+25^{\circ} \mathrm{C}\) & I & 120 & 170 & 220 & 120 & 170 & 220 & \(\Omega\) \\
\hline & Full & VI & 80 & & 270 & 80 & & 270 & \\
\hline Ladder Tempco & Full & V & & 0.45 & & & 0.45 & & \(\Omega /{ }^{\circ} \mathrm{C}\) \\
\hline Reference Ladder Offset & \(+25^{\circ} \mathrm{C}\) & I & & 8 & 16 & & 8 & 16 & mV \\
\hline (Top) & Full & VI & & & 24 & & & 24 & mV \\
\hline Reference Ladder Offset & \(+25^{\circ} \mathrm{C}\) & I & & 8 & 23 & & 8 & 23 & mV \\
\hline (Bottom) & Full & VI & & & 33 & & & 33 & mV \\
\hline Offset Drift Coefficient & Full & V & & 50 & & & 50 & & \(\mu \mathrm{V} /{ }^{\circ} \mathrm{C}\) \\
\hline \multicolumn{10}{|l|}{INTERNAL VOLTAGE REFERENCE} \\
\hline Reference Voltage & \(+25^{\circ} \mathrm{C}\) & I & 1.95 & 2.0 & 2.20 & 1.95 & 2.0 & 2.20 & V \\
\hline & Full & VI & 1.90 & & 2.25 & 1.90 & & 2.25 & V \\
\hline Temperature Coefficient & Full & V & & 150 & & & 150 & & \(\mu \mathrm{V} /{ }^{\circ} \mathrm{C}\) \\
\hline \begin{tabular}{l}
Power Supply \\
Rejection Ratio (PSRR)
\end{tabular} & \(+25^{\circ} \mathrm{C}\) & & & & 25 & & & & \\
\hline Rejection Ratio (PSRR) & \(+25^{\circ}\) & 1 & & 10 & 25 & & 10 & 25 & mVN \\
\hline \multicolumn{10}{|l|}{SWITCHING PERFORMANCE} \\
\hline Maximum Conversion Rate \({ }^{4}\) & \(+25^{\circ} \mathrm{C}\) & I & & 50 & & 50 & 60 & & MSPS \\
\hline Aperture Delay ( \(\mathrm{t}_{\mathrm{A}}\) ) & \(+25^{\circ} \mathrm{C}\) & IV & 0.1 & 0.8 & 1.5 & 0.1 & 0.8 & 1.5 & \\
\hline Aperture Delay Matching & \(+25^{\circ} \mathrm{C}\) & IV & & 0.2 & 0.5 & & 0.2 & 0.5 & ns \\
\hline Aperture Uncertainty (Jitter) & \(+25^{\circ} \mathrm{C}\) & V & & 10 & & & 10 & & ps, rms \\
\hline Output Delay (Valid) ( \(\left.\mathrm{t}_{\mathrm{v}}\right)^{4}\) & \(+25^{\circ} \mathrm{C}\) & I & & 8 & & 5 & 8 & & \\
\hline Output Delay ( \(\mathrm{t}_{\mathrm{v}}\) ) Tempco & Full & V & & 16 & & & 16 & & ps/ \(/{ }^{\text {C }}\) \\
\hline Propagation Delay ( tPD\()^{4}\) & \(+25^{\circ} \mathrm{C}\) & I & & 12 & & & 12 & 19 & \\
\hline Propagation Delay ( \(\mathrm{t}_{\mathrm{PD}}\) ) Tempco & Full & V & & -16 & & & -16 & & \(\mathrm{ps} /{ }^{\circ} \mathrm{C}\) \\
\hline Output Time Skew & \(+25^{\circ} \mathrm{C}\) & V & & 1 & & & 1 & & ns \\
\hline \multicolumn{10}{|l|}{ENCODE INPUT} \\
\hline Logic " 1 " Voltage & Full & VI & 2 & & & 2 & & & V \\
\hline Logic "0" Voltage & Full & VI & & & 0.8 & & & 0.8 & V \\
\hline Logic " 1 " Current & Full & VI & & & 600 & & & 600 & \(\mu \mathrm{A}\) \\
\hline Logic "0" Current & Full & VI & & & 1000 & & & 1000 & \(\mu \mathrm{A}\) \\
\hline Input Capacitance & \(+25^{\circ} \mathrm{C}\) & V & & 5 & & & 5 & & pF \\
\hline Pulse Width (High) & \(+25^{\circ} \mathrm{C}\) & I & & 8 & & 8 & & & ns \\
\hline Pulse Width (Low) & \(+25^{\circ} \mathrm{C}\) & I & & 8 & & 8 & & & ns \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Parameter (Conditions)} & \multirow[b]{2}{*}{Temp} & \multirow[t]{2}{*}{Test Level} & \multicolumn{3}{|c|}{AD9058JD/JJ} & \multicolumn{3}{|c|}{AD9058KD/KJ} & \multirow[b]{2}{*}{Units} \\
\hline & & & Min & Typ & Max & Min & Typ & Max & \\
\hline \multicolumn{10}{|l|}{DYNAMIC PERFORMANCE} \\
\hline Transient Response & \(+25^{\circ} \mathrm{C}\) & V & & 2 & & & 2 & & ns \\
\hline Overvoltage Recovery Time & \(+25^{\circ} \mathrm{C}\) & V & & 2 & & & 2 & & ns \\
\hline Effective Number of Bits (ENOB) \({ }^{5}\) & & & & & & & & & \\
\hline Analog Input @ 2.3 MHz & \(+25^{\circ} \mathrm{C}\) & I & & 7.7 & & 7.2 & 7.7 & & Bits \\
\hline @ 10.3 MHz & \(+25^{\circ} \mathrm{C}\) & I & & 7.4 & & 7.1 & 7.4 & & Bits \\
\hline \multicolumn{10}{|l|}{Signal-to-Noise Ratio \({ }^{5}\) ( \({ }^{\text {S }}\)} \\
\hline Analog Input @ 2.3 MHz & \(+25^{\circ} \mathrm{C}\) & I & & 48 & & 45 & 48 & & dB \\
\hline @ 10.3 MHz & \(+25^{\circ} \mathrm{C}\) & I & & 46 & & 44 & 46 & & dB \\
\hline \multicolumn{10}{|l|}{Signal-to-Noise Ratio \({ }^{5}\) (Without Harmonics)} \\
\hline Analog Input @ 2.3 MHz & \(+25^{\circ} \mathrm{C}\) & I & & 48 & & 46 & 48 & & dB \\
\hline - @ 10.3 MHz & \(+25^{\circ} \mathrm{C}\) & I & & 47 & & 45 & 47 & & dB \\
\hline \multicolumn{10}{|l|}{2nd Harmonic Distortion} \\
\hline Analog Input @ 2.3 MHz & \(+25^{\circ} \mathrm{C}\) & I & & 58 & & 48 & 58 & & dBc \\
\hline @ 10.3 MHz & \(+25^{\circ} \mathrm{C}\) & I & & 58 & & 48 & 58 & & dBc \\
\hline \multicolumn{10}{|l|}{3rd Harmonic Distortion} \\
\hline Analog Input @ 2.3 MHz & \(+25^{\circ} \mathrm{C}\) & I & & 58 & & 50 & 58 & & dBc \\
\hline @ 10.3 MHz & \(+25^{\circ} \mathrm{C}\) & I & & 58 & & 50 & 58 & & dBc \\
\hline Crosstalk Rejection \({ }^{6}\) & \(+25^{\circ} \mathrm{C}\) & IV & & 60 & & 48 & 60 & & dBc \\
\hline \multicolumn{10}{|l|}{DIGITAL OUTPUTS} \\
\hline Logic " 1 " Voltage ( \(\mathrm{I}_{\mathrm{OH}}=2 \mathrm{~mA}\) ) & Full & VI & 2.4 & & & 2.4 & & & V \\
\hline Logic " 0 " Voltage ( \(\mathrm{I}_{\mathrm{OL}}=2 \mathrm{~mA}\) ) & Full & VI & & & 0.4 & & & 0.4 & V \\
\hline \multicolumn{10}{|l|}{POWER SUPPLY \({ }^{7}\)} \\
\hline + \(\mathrm{V}_{\text {S }}\) Supply Current & Full & VI & & 127 & 154 & & 127 & 154 & mA \\
\hline - V \({ }_{\text {S }}\) Supply Current & Full & VI & & 27 & 38 & & 27 & 38 & mA \\
\hline Power Dissipation & Full & VI & & 770 & 960 & & 770 & 960 & mW \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Absolute maximum ratings are limiting values to be applied individually, and beyond which the serviceability of the circuit may be impaired. Functional operability is not necessarily implied. Exposure to absolute maximum rating conditions for an extended period of time may affect device reliability.
\({ }^{2}\) For applications in which \(+\mathrm{V}_{\mathrm{S}}\) may be applied before \(-\mathrm{V}_{\mathrm{S}}\), or \(+\mathrm{V}_{\mathrm{S}}\) current is not limited to 500 mA , a reverse biased clamping diode should be inserted between ground and \(-V_{s}\) to prevent destructive latch up. See section entitled "Using the AD9058."
\({ }^{3}\) Typical thermal impedances: 44 -pin hermetic J-Leaded ceramic package: \(\theta_{\mathrm{JA}}=86.4^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=24.9^{\circ} \mathrm{C} / \mathrm{W} ; 48\)-pin hermetic DIP \(\theta_{\mathrm{JA}}=40^{\circ} \mathrm{C} / \mathrm{W}\); \(\theta_{1 \mathrm{C}}=12^{\circ} \mathrm{C} / \mathrm{W}\).
\({ }^{4}\) To achieve guaranteed conversion rate, connect each data output to ground through a \(2 \mathrm{k} \Omega\) pull-down resistor.
"SNR performance limits for the 48 -pin DIP "D" package are 1 dB less than shown. ENOB limits are degraded by 0.3 dB . SNR and ENOB measured with analog input signal 1 dB below full scale at specified frequency.
\({ }^{6}\) Crosstalk rejection measured with full-scale signals of different frequencies ( 2.3 MHz and 3.5 MHz ) applied to each channel. With both signals synchronously encoded at 40 MSPS, isolation of the undesired frequency is measured with an FFT.
\({ }^{7}\) Applies to both A/Ds and includes internal ladder dissipation.
Specifications subject to change without notice.

\section*{EXPLANATION OF TEST LEVELS}

\section*{Test Level}

I - \(100 \%\) production tested.
II - \(100 \%\) production tested at \(+25^{\circ} \mathrm{C}\), and sample tested at specified temperatures.
III - Sample tested only.
IV - Parameter is guaranteed by design and characterization testing.
V - Parameter is a typical value only.
VI - All devices are \(100 \%\) production tested at \(+25^{\circ} \mathrm{C}\). \(100 \%\) production tested at temperature extremes for extended temperature devices; sample tested at temperature extremes for commercial/industrial devices.

ORDERING GUIDE
\begin{tabular}{|c|c|c|c|}
\hline Model & Temperature Range & Description & Package Option* \\
\hline AD9058JJ & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & \[
\begin{aligned}
& \text { 44-Pin J-Leaded } \\
& \text { Ceramic }
\end{aligned}
\] & J-44 \\
\hline AD9058KJ & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & 44-Pin J-Leaded Ceramic, AC Tested & J-44 \\
\hline AD9058TJ/883\# & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 44-Pin J-Leaded Ceramic, AC Tested & J-44 \\
\hline AD9058JD & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & 48-Pin Ceramic DIP & D-48 \\
\hline AD9058KD & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & 48-Pin Ceramic DIP, AC Tested & D-48 \\
\hline AD9058TD/883\# & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 48-Pin Ceramic DIP,
AC Tested & D-48 \\
\hline AD9058/PCB & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & AD9058 Evaluation Board (J-Lead) & \\
\hline
\end{tabular}

\footnotetext{
*D = Hermetic Ceramic DIP Package; J = Leaded Ceramic Package. For outline information see Package Information section.
\(\dagger\) Hermetically sealed ceramic package; footprint equivalent to PLCC.
\#For specifications, refer to Analog Devices Military Products Databook.
}

\section*{PIN DESCRIPTIONS}



AD9058JJ/KJ Pinouts


AD9058 Equivalent Encode Circuit


AD9058JD/KD Pinouts


INDICATES EACH PIN IS CONNECTED THRU \(2 \mathrm{k} \Omega\)
* *INDICATES EACH PIN IS CONNECTED THROUGH \(100 \Omega\)

\author{
Monolithic 10-Bit/75 MSPS Converter \\ ECL Outputs \\ Bipolar ( \(\pm 1.75\) V) Analog Input \\ 57 dB SNR @ 2.3 MHz Input \\ Low (45 pF) Input Capacitance \\ MIL-STD-883 Compliant Versions Available
}

FEATURES

APPLICATIONS
Digital Oscilloscopes
Medical Imaging
Professional Video
Radar Warning/Guidance Systems
Infrared Systems

\section*{GENERAL DESCRIPTION}

The AD9060 A/D converter is a 10 -bit monolithic converter capable of word rates of 75 MSPS and above. Innovative architecture using 512 input comparators instead of the traditional 1024 required by other flash converters reduces input capacitance and improves linearity.
Inputs and outputs are ECL-compatible, which makes the AD9060 the recommended choice for systems with conversion rates \(>30\) MSPS, to minimize system noise. An overflow bit is provided to indicate analog input signals greater than \(+\mathrm{V}_{\text {SENSE }}\). Voltage sense lines are provided to insure accurate driving of the \(\pm \mathrm{V}_{\mathrm{REF}}\) voltages applied to the units. Quarter-point taps on the resistor ladder help optimize the integral linearity of the unit.
Either 68-pin ceramic leaded (gull wing) packages or ceramic LCCs are available and are specifically designed for low thermal impedances. Two performance grades for temperatures of both 0 to. \(+70^{\circ} \mathrm{C}\) and \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) ranges are offered to allow the user to select the linearity best suited for each application. Dynamic performance is fully characterized and production tested at \(+25^{\circ} \mathrm{C}\). MIL-STD-883 units are available.

The AD9060 A/D converter is available in versions compliant with MIL-STD-883. Refer to the Analog Devices Military Products Databook or current AD9060/883B data sheet for detailed specifications.

FUNCTIONAL BLOCK DIAGRAM


ORDERING GUIDE
\begin{tabular}{|c|c|c|}
\hline Device & Temperature Range & Package Option \({ }^{1}\) \\
\hline AD9060JZ & 0 to \(+70^{\circ} \mathrm{C}\) & Z-68 \\
\hline AD9060JE & 0 to \(+70^{\circ} \mathrm{C}\) & E-68A \\
\hline AD9060KZ & 0 to \(+70^{\circ} \mathrm{C}\) & Z-68 \\
\hline AD9060KE & 0 to \(+70^{\circ} \mathrm{C}\) & E-68A \\
\hline AD9060SZ \({ }^{2}\) & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & Z-68 \\
\hline AD9060SE \({ }^{2}\) & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & E-68A \\
\hline AD9060TZ \({ }^{2}\) & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & Z-68 \\
\hline AD9060TE \({ }^{2}\) & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & E-68A \\
\hline AD9060/PCB & 0 to \(+70^{\circ} \mathrm{C}\) & Evaluation Board \\
\hline
\end{tabular}

\footnotetext{
NOTES
\({ }^{1} E=\) Ceramic Leadless Chip Carrier; Z \(=\) Ceramic Leaded Chip Carrier. For outline information see Package Information section.
\({ }^{2}\) For specifications, refer to Analog Devices Military Products Databook.
}

\section*{AD9060-SPECIFICATIONS}

ABSOLUTE MAXIMUM RATINGS \({ }^{1}\)
\begin{tabular}{|c|c|}
\hline \multicolumn{2}{|l|}{\multirow[t]{2}{*}{}} \\
\hline & \\
\hline
\end{tabular}
\(\therefore-6\) V
ANALOG IN . . . . . . . . . . . . . . . . . . . . . . . -2 V to +2 V \(+\mathrm{V}_{\text {REF }},-\mathrm{V}_{\mathrm{REF}}, 3 / 4_{\mathrm{REF}}, 1 / 2_{\text {REF }}, 1 / 4_{\text {REF }} \ldots . .-2 \mathrm{~V}\) to +2 V
\(+\mathrm{V}_{\mathrm{REF}}\) to \(-\mathrm{V}_{\mathrm{REF}}\). . . . . . . . . . . . . . . . . . . . . . . . . 4.0 V
ENCODE, \(\overline{\text { ENCODE }}\). . . . . . . . . . . . . . . . . . . 0 V to \(-V_{s}\)
\(3 / 4_{\text {REF }}, 1 / 2_{\text {REF }}, 1 / 4_{\text {REF }}\) Current . . . . . . . . . . . . . . . \(\pm 10 \mathrm{~mA}\) Digital Output Current 20 mA Operating Temperature

AD9060JE/KE/JZ/KZ . . . . . . . . . . . . . . . . . . 0 to \(+70^{\circ} \mathrm{C}\)
Storage Temperature . . . . . . . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Maximum Junction Temperature \({ }^{2}\). . . . . . . . . . . . . . \(+175^{\circ} \mathrm{C}\)
Lead Soldering Temp (10 sec) . . . . . . . . . . . . . . . . \(+300^{\circ} \mathrm{C}\)

ELECTRICAL CHARACTERISTICS \(\begin{gathered}\left(+V_{s}=+5 \mathrm{~V}_{\mathrm{s}} ;-\mathrm{V}_{\mathrm{s}}=-5.2 \mathrm{~V} ; \pm \mathrm{V}_{\text {sense }}= \pm 1.75 \mathrm{~V} \text {; ENCODE }=60 \mathrm{MSPS}, ~\right.\end{gathered}\)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Parameter (Conditions)} & \multirow[b]{2}{*}{Temp} & \multirow[t]{2}{*}{Test Level} & \multicolumn{3}{|c|}{AD9060JE/JZ} & \multicolumn{3}{|c|}{AD9060KE/KZ} & \multirow[b]{2}{*}{Units} \\
\hline & & & Min & Typ & Max & Min & Typ & Max & \\
\hline RESOLUTION & & & 10 & & & 10 & & & Bits \\
\hline \multicolumn{10}{|l|}{DC ACCURACY \({ }^{3}\)} \\
\hline Differential Nonlinearity & \(+25^{\circ} \mathrm{C}\) & I & & 1.0 & 1.25 & & 0.75 & 1.0 & LSB \\
\hline & Full & VI & & & 1.5 & & & 1.25 & LSB \\
\hline Integral Nonlinearity & \(+25^{\circ} \mathrm{C}\) & I & & 1.25 & 2.0 & & 1.0 & 1.5 & LSB \\
\hline & Full & VI & & & 2.5 & & & 2.0 & LSB \\
\hline No Missing Codes & Full & VI & & & & & arant & & \\
\hline \multicolumn{10}{|l|}{ANALOG INPUT} \\
\hline Input Bias Current \({ }^{4}\) & \(+25^{\circ} \mathrm{C}\) & I & & 0.4 & 1.0 & & 0.4 & 1.0 & mA \\
\hline & Full & VI & & & 2.0 & & & 2.0 & mA \\
\hline Input Resistance & \(+25^{\circ} \mathrm{C}\) & I & 2.0 & 7.0 & & 2.0 & 7.0 & & \(\mathrm{k} \Omega\) \\
\hline Input Capacitance \({ }^{4}\) & \(+25^{\circ} \mathrm{C}\) & V & & 45 & & & 45 & & pF \\
\hline Analog Bandwidth & \(+25^{\circ} \mathrm{C}\) & V & & 175 & & & 175 & & MHz \\
\hline \multicolumn{10}{|l|}{REFERENCE INPUT} \\
\hline Reference Ladder Resistance & \(+25^{\circ} \mathrm{C}\) & I & 22 & 37 & 56 & 22 & 37 & 56 & \(\boldsymbol{\Omega}\) \\
\hline & Full & VI & 14 & & 66 & 14 & & 66 & \(\Omega\) \\
\hline Ladder Tempco & Full & V & & 0.1 & & & 0.1 & & \(\Omega /{ }^{\circ} \mathrm{C}\) \\
\hline \multicolumn{10}{|l|}{Reference Ladder Offset} \\
\hline Top of Ladder & \(+25^{\circ} \mathrm{C}\) & I & & 45 & 90 & & 45 & 90 & mV \\
\hline & Full & VI & & & 90 & & & 90 & mV \\
\hline Bottom of Ladder & \(+25^{\circ} \mathrm{C}\) & I & & 45 & 90 & & 45 & 90 & mV \\
\hline & Full & VI & & & 90 & & & 90 & mV \\
\hline Offset Drift Coefficient & Full & V & & 50 & & & 50 & & \(\mu \mathrm{V} /{ }^{\circ} \mathrm{C}\) \\
\hline \multicolumn{10}{|l|}{SWITCHING PERFORMANCE} \\
\hline Conversion Rate & \(+25^{\circ} \mathrm{C}\) & I & 75 & & & 75 & & & MSPS \\
\hline Aperture Delay ( \(\mathrm{t}_{\mathrm{A}}\) ) & \(+25^{\circ} \mathrm{C}\) & V & & 1 & & & 1 & & ns \\
\hline Aperture Uncertainty (Jitter) & \(+25^{\circ} \mathrm{C}\) & V & & 5 & & & 5 & & ps, rms \\
\hline Output Delay ( \(\left.\mathrm{t}_{\text {OD }}\right)^{5}\) & \(+25^{\circ} \mathrm{C}\) & I & 2 & 4 & 9 & 2 & 4 & 9 & ns \\
\hline Output Rise Time & \(+25^{\circ} \mathrm{C}\) & I & & 1 & 3 & & 1 & 3 & ns \\
\hline Output Fall Time & \(+25^{\circ} \mathrm{C}\) & I & & 1 & 3 & & 1 & 3 & ns \\
\hline Output Time Skew \({ }^{\text {s }}\) & \(+25^{\circ} \mathrm{C}\) & I & & 1.5 & 3 & & 1.5 & 3 & ns \\
\hline \multicolumn{10}{|l|}{DYNAMIC PERFORMANCE} \\
\hline Transient Response & \(+25^{\circ} \mathrm{C}\) & V & & 10 & & & 10 & & ns \\
\hline Overvoltage Recovery Time & \(+25^{\circ} \mathrm{C}\) & V & & 10 & & & 10 & & ns \\
\hline \multicolumn{10}{|l|}{Effective Number of Bits (ENOB)} \\
\hline \(\mathrm{f}_{\mathrm{IN}}=2.3 \mathrm{MHz}\) & \(+25^{\circ} \mathrm{C}\) & I & 8.7 & 9.1 & & 8.7 & 9.1 & & Bits \\
\hline \(\mathrm{f}_{\mathrm{IN}}=10.3 \mathrm{MHz}\) & \(+25^{\circ} \mathrm{C}\) & IV & 8.0 & 8.6 & & 8.0 & 8.6 & & Bits \\
\hline \(\mathrm{f}_{\mathrm{IN}}=29.3 \mathrm{MHz}\) & \(+25^{\circ} \mathrm{C}\) & IV & 7.0 & 7.4 & & 7.0 & 7.4 & & Bits \\
\hline \multicolumn{10}{|l|}{Signal-to-Noise Ratio \({ }^{6}\)} \\
\hline \(\mathrm{f}_{\mathrm{IN}}=2.3 \mathrm{MHz}\) & \(+25^{\circ} \mathrm{C}\) & I & 54 & 56 & & 54 & 56 & & dB \\
\hline \(\mathrm{f}_{\mathrm{IN}}=10.3 \mathrm{MHz}\) & \(+25^{\circ} \mathrm{C}\) & I & 51 & 54 & & 51 & 54 & & dB \\
\hline \(\mathrm{f}_{\mathrm{IN}}=29.3 \mathrm{MHz}\) & \(+25^{\circ} \mathrm{C}\) & 1 & 44 & 47 & & 44 & 47 & & dB \\
\hline
\end{tabular}

AD9060
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Parameter (Conditions)} & \multirow[b]{2}{*}{Temp} & \multirow[t]{2}{*}{\begin{tabular}{l}
Test \\
Level
\end{tabular}} & \multicolumn{3}{|c|}{AD9060JE/JZ} & \multicolumn{3}{|c|}{AD9060KE/KZ} & \multirow[b]{2}{*}{Units} \\
\hline & & & Min & Typ & Max & Min & Typ & Max & \\
\hline \multicolumn{10}{|l|}{DYNAMIC PERFORMANCE (CONTINUED)} \\
\hline \multicolumn{10}{|l|}{Signal-to-Noise Ratio \({ }^{6}\)} \\
\hline \multicolumn{10}{|l|}{(Without Harmonics)} \\
\hline \(\mathrm{f}_{\mathrm{IN}}=2.3 \mathrm{MHz}\) & \(+25^{\circ} \mathrm{C}\) & I & 54 & 56 & & 54 & 58 & & dB \\
\hline \(\mathrm{f}_{\mathrm{IN}}=10.3 \mathrm{MHz}\) & \(+25^{\circ} \mathrm{C}\) & I & 51 & 55 & & 51 & 55 & & dB \\
\hline \(\mathrm{f}_{\mathrm{IN}}=29.3 \mathrm{MHz}\) & \(+25^{\circ} \mathrm{C}\) & I & 46 & 48 & & 46 & 48 & & dB \\
\hline \multicolumn{10}{|l|}{Harmonic Distortion} \\
\hline \(\mathrm{f}_{\mathrm{IN}}=2.3 \mathrm{MHz}\) & \(+25^{\circ} \mathrm{C}\) & I & 61 & 65 & & 61 & 65 & & dBc \\
\hline \(\mathrm{f}_{\mathrm{IN}}=10.3 \mathrm{MHz}\) & \(+25^{\circ} \mathrm{C}\) & I & 55 & 58 & & 55 & 58 & & dBc \\
\hline \(\mathrm{f}_{\mathrm{IN}}=29.3 \mathrm{MHz}\) & \(+25^{\circ} \mathrm{C}\) & I & 47 & 50 & & 47 & 50 & & dBc \\
\hline \multicolumn{10}{|l|}{Two-Tone Intermodulation} \\
\hline Distortion Rejection \({ }^{7}\) & \(+25^{\circ} \mathrm{C}\) & V & & 70 & & & 70 & & dBc \\
\hline Differential Phase & \(+25^{\circ} \mathrm{C}\) & V & & 0.5 & & & 0.5 & & Degree \\
\hline Differential Gain & \(+25^{\circ} \mathrm{C}\) & V & & 1 & & & 1 & & \% \\
\hline \multicolumn{10}{|l|}{ENCODE INPUT} \\
\hline Logic " 1 " Voltage & Full & VI & -1.1 & & & -1.1 & & & V \\
\hline Logic "0" Voltage & Full & VI & & & -1.5 & & & -1.5 & V \\
\hline Logic " 1 " Current & Full & VI & & 150 & 300 & & 150 & 300 & \(\mu \mathrm{A}\) \\
\hline Logic " 0 " Current & Full & VI & & 150 & 300 & & 150 & 300 & \(\mu \mathrm{A}\) \\
\hline Input Capacitance & \(+25^{\circ} \mathrm{C}\) & V & & 5 & & & 5 & & pF \\
\hline Pulse Width (High) & \(+25^{\circ} \mathrm{C}\) & I & 6 & & & 6 & & & ns \\
\hline Pulse Width (Low) & \(+25^{\circ} \mathrm{C}\) & I & 6 & & & 6 & & & ns \\
\hline \multicolumn{10}{|l|}{DIGITAL OUTPUTS} \\
\hline Logic "l" Voltage & Full & VI & -1.1 & & & -1.1 & & & V \\
\hline Logic "0" Voltage & Full & VI & & & -1.5 & & & -1.5 & V \\
\hline \multicolumn{10}{|l|}{POWER SUPPLY} \\
\hline + \(\mathrm{V}_{\text {S }}\) Supply Current & \(+25^{\circ} \mathrm{C}\) & VI & & 420 & 500 & & 420 & 500 & mA \\
\hline & Full & VI & & & 500 & & & 500 & mA \\
\hline - \(\mathrm{V}_{\text {S }}\) Supply Current & \(+25^{\circ} \mathrm{C}\) & VI & & 150 & 180 & & 150 & 180 & mA \\
\hline & Full & VI & & & 190 & & & 190 & mA \\
\hline Power Dissipation & \(+25^{\circ} \mathrm{C}\) & VI & & 2.8 & 3.3 & & 2.8 & 3.3 & W \\
\hline & Full & VI & & & 3.5 & & & 3.5 & W \\
\hline Power Supply Rejection Ratio (PSRR) \({ }^{8}\) & Full & VI & & 6 & 10 & & 6 & 10 & \(\mathrm{mV} / \mathrm{V}\) \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Absolute maximum ratings are limiting values to be applied individually, and beyond which the serviceability of the circuit may be impaired. Functional operability is not necessarily implied. Exposure to absolute maximum rating conditions for an extended period of time may affect device reliability.
\({ }^{2}\) Typical thermal impedances (part soldered onto board): 68-pin leaded ceramic chip carrier: \(\theta_{\mathrm{JC}}=1{ }^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JA}}=17^{\circ} \mathrm{C} / \mathrm{W}\) (no air flow); \(\theta_{\mathrm{JA}}=15^{\circ} \mathrm{C} / \mathrm{W}\) (air flow \(=500 \mathrm{LFM}\) ). 68-pin ceramic LCC: \(\theta_{\mathrm{JC}}=2.6^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JA}}=15^{\circ} \mathrm{C} / \mathrm{W}\) (no air flow); \(\theta_{\mathrm{JA}}=13^{\circ} \mathrm{C} / \mathrm{W}\) (air flow \(=500 \mathrm{LFM}\) ).
\({ }^{3} 3 / 4_{\text {REF }}, 1 / 2_{\text {REF }}\), and \(1 / 4_{\text {REF }}\) reference ladder taps are driven from dc sources at \(+0.875 \mathrm{~V}, 0 \mathrm{~V}\), and -0.875 V , respectively. Outputs terminated through \(100 \Omega\) to \(-2.0 \mathrm{~V} ; \mathrm{C}_{\mathrm{L}}<4 \mathrm{pF}\). Accuracy of the overflow comparator is not tested and not included in linearity specifications.
\({ }^{4}\) Measured with ANALOG IN \(=+\mathrm{V}_{\text {SENSE }}\).
\({ }^{5}\) Output delay measured as worst-case time from \(50 \%\) point of the rising edge of ENCODE to \(50 \%\) point of the slowest rising or falling edge of \(D_{0}-D_{9}\). Output skew measured as worst-case difference in output delay among \(\mathrm{D}_{0}-\mathrm{D}_{9}\).
\({ }^{6}\) RMS signal to rms noise with analog input signal 1 dB below full scale at specified frequency.
\({ }^{7}\) Intermodulation measured with analog input frequencies of 2.3 MHz and 3.0 MHz at 7 dB below full scale.
\({ }^{8}\) Measured as the ratio of the worst-case change in transition voltage of a single comparator for a \(5 \%\) change in \(+\mathrm{V}_{\mathrm{s}}\) or \(-\mathrm{V}_{\mathrm{S}}\).
Specifications subject to change without notice.

\section*{EXPLANATION OF TEST LEVELS}

\section*{Test Level}

I - \(100 \%\) production tested.
II - \(100 \%\) production tested at \(+25^{\circ} \mathrm{C}\), and sample tested at specified temperatures.
III - Sample tested only.
IV - Parameter is guaranteed by design and characterization testing.

V - Parameter is a typical value only.
VI - All devices are \(100 \%\) production tested at \(+25^{\circ} \mathrm{C}\). \(100 \%\) production tested at temperature extremes for extended temperature devices; sample tested at temperature extremes for commercial/industrial devices.


AD9060 PIN DESCRIPTIONS
\begin{tabular}{|c|c|c|}
\hline Pin No. & Name & Function \\
\hline 1 & \(1 / 2_{\text {REF }}\) & Midpoint of internal reference ladder. \\
\hline \[
\begin{aligned}
& 2,16,28,29,35, \\
& 41,42,54,64
\end{aligned}
\] & \(-\mathrm{V}_{\mathbf{S}}\) & Negative supply voltage; nominally \(-5.2 \mathrm{~V} \pm 5 \%\). \\
\hline \[
\begin{aligned}
& 3,6,15,30,33,34 \\
& 37,40,65,68
\end{aligned}
\] & \(+\mathrm{V}_{s}\) & Positive supply voltage; nominally \(+5 \mathrm{~V} \pm 5 \%\). \\
\hline \[
\begin{aligned}
& 4,5,17,18,25,27, \\
& 31,32,36,38,39,43 \\
& 45,52,53,66,67
\end{aligned}
\] & GROUND & All ground pins should be connected together and to lowimpedance ground plane. \\
\hline 7 & \(3 / 4_{\text {REF }}\) & Three-quarter point of internal reference ladder. \\
\hline 8, 9 & ANALOG IN & Analog input; nominally between \(\pm 1.75 \mathrm{~V}\). \\
\hline 11 & \(+\mathrm{V}_{\text {SENSE }}\) & Voltage sense line to most positive point on internal resistor ladder. Normally +1.75 V . \\
\hline 12 & \(+\mathrm{V}_{\text {REF }}\) & Voltage force connection for top of internal reference ladder. Normally driven to provide +1.75 V at \(+\mathrm{V}_{\text {SENSE }}\). \\
\hline 13 & ENCODE & Differential ECL convert signal which starts digitizing process. \\
\hline 14 & ENCODE & ECL-compatible convert command used to begin digitizing process. \\
\hline 19-23, 46-50 & \(\mathrm{D}_{0}-\mathrm{D}_{9}\) & ECL-compatible digital output data. \\
\hline 51 & OVERFLOW & ECL-compatible output indicating ANALOG IN > \(+V_{\text {SENSE }}\). \\
\hline 56 & \(-\mathrm{V}_{\text {REF }}\) & Voltage force connection for botrom of internal reference ladder. Normally driven to provide -1.75 V at \(-\mathrm{V}_{\text {SENSE }}\). \\
\hline 57 & \(-\mathrm{V}_{\text {SENSE }}\) & Voltage sense line to most negative point on internal resistor ladder. Normally -1.75 V . \\
\hline 59 & LSBs INVERT & Normally grounded. When connected to \(+\mathrm{V}_{\mathrm{S}}\), lower order bits \(\left(D_{0}-D_{8}\right)\) are inverted. Not ECL-compatible. \\
\hline 61 & MSB INVERT & Normally grounded. When connected to \(+V_{S}\), most significant bit (MSB; \(\mathrm{D}_{\boldsymbol{9}}\) ) is inverted. Not ECL-compatible. \\
\hline 63 & \(1 / 4_{\text {REF }}\) & One-quarter point of internal reference ladder. \\
\hline
\end{tabular}
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Selection Trees - Digital-to-Analog Converters



\section*{Selection Trees - Digital-to-Analog Converters}



Selection Trees - Digital-to-Analog Converters


\section*{Selection Guides-Digital-to-Analog Converters}

\section*{Single DACs, Voltage Output}
\begin{tabular}{|c|c|c|c|c|c|c|c|c|}
\hline Model & Res Bits & Settling Time \(\mu \mathrm{s}\) typ & \begin{tabular}{l}
Bus \\
Interface Bits \({ }^{1}\)
\end{tabular} & \begin{tabular}{l}
Reference \\
Volt \\
Int/Ext (M) \({ }^{\mathbf{2}}\)
\end{tabular} & Package Options \({ }^{3}\) & Temp Ranges \({ }^{4}\) & Comments & Page \({ }^{5}\) \\
\hline AD557 & 8 & 0.8 & 8, \(\mu \mathrm{P}\) & Int & N, \(\mathbf{P}\) & C & Lowest Cost 8-Bit DACPORT \({ }^{\text {® }}\); Single +5 V Supply & 3-24 \\
\hline AD7569 & 8 & 1.0 & 8, \(\mu \mathrm{P}\) & Int & E, N, P, Q, R & C, I, M/ \({ }_{\text {D }}\) & CMOS, Complete 8-Bit DAC/ADC/SHA/Reference & CII 8-7 \\
\hline AD558 & 8 & 3.0 & 8, \(\mu \mathrm{P}\) & Int & D, E, N, P & C, M/ \({ }_{\text {d }}\) & 10 V Out DACPORT, Single or Dual Supply & 3-26 \\
\hline AD7224 & 8 & 5.0 (max) & 8, \(\mu \mathrm{P}\) & 2-12.5 V, Ext & \(\mathbf{E}, \mathbf{N}, \mathbf{P}, \mathbf{Q}, \mathbf{R}\) & C, I, M/s & CMOS, Low Cost 8-Bit DAC & 3-107 \\
\hline AD7848 & 12 & 2.5 & 12, \(\mu \mathrm{P}\) & Int ( +3 V ), Ext & N, P, Q & C, I & CMOS, Complete 12-Bit DAC with 8-Word FIFO & CI 2-735 \\
\hline AD7845 & 12 & 2.5 & 12, \(\mu \mathrm{P}\) & Ext (M) & \(\mathbf{E}, \mathbf{N}, \mathbf{P}, \mathbf{Q}, \mathbf{R}\) & C, \(\mathbf{I}, \mathrm{M} / \mathrm{D}\) & CMOS, 12-Bit Multiplying DAC with Output Amplifier & 3-213 \\
\hline AD667 & 12 & 3.0 & 4/8/12, \(\mu \mathrm{P}\) & 10 V , Int & D, E, N, P & \(\mathrm{C}, \mathrm{I}, \mathrm{M} / \mathrm{DS}\) & Highest Accuracy Complete 12-Bit DAC & 3-59 \\
\hline AD767 & 12 & 3.0 & 12, \(\mu \mathrm{P}\) & 10 V , Int & D, N & C, I, M/ \({ }_{\text {DS }}\) & Fastest Interface Complete 12-Bit DAC & 3-86 \\
\hline AD DAC80/85/87 & 12 & 3 & 12 & Int (6.3 V), Ext & D, N & C, I, M & General Purpose 12-Bit DAC & 3-285 \\
\hline AD7233 & 12 & 10 (max) & Serial, \(\boldsymbol{\mu} \mathbf{P}\) & Int & N & I & Smallest 12-Bit Serial DACPORT (8-Pin) Bipolar \(\pm 5 \mathrm{~V}\) Output Range & 3-123 \\
\hline AD7243 & 12 & 10 (max) & Serial & Int (+5 V), Ext & \(\mathbf{N}, \mathbf{Q}, \mathbf{R}\) & I, M/ \({ }_{\text {D }}\) & Low Cost 12-Bit Serial DACPORT in 16-Pin SOP & 3-137 \\
\hline AD7245A & 12 & 10 (max) & 12, \(\mu \mathrm{P}\) & 5 V , Int & \(\mathbf{E}, \mathbf{N}, \mathbf{P}, \mathbf{Q}, \mathbf{R}\) & C, I, M/ \({ }_{\text {D }}\) & Faster Interface, 12 V and 15 V AD7245 & 3-141 \\
\hline AD7248A & 12 & 10 (max) & 8, \(\mu \mathrm{P}\) & 5 V , Int & \(\mathbf{N}, \mathbf{P}, \mathbf{Q}, \mathbf{R}\) & C, I, M/b & Faster Interface, 12 V and 15 V AD7248 & 3-141 \\
\hline DAC8512 & 12 & 16 & Serial, \(\boldsymbol{\mu} \mathrm{P}\) & Int & N, R & I & 5 Volt Supply, Complete 12-Bit DAC, Serial Input & 3-356 \\
\hline DAC8562 & 12 & 16 & 12, \(\mu \mathrm{P}\) & Int ( 2.5 V ) & N, R & I, M & 5 Volt Supply, Complete 12-Bit DAC, Parallel Input & 3-375 \\
\hline AD7840 & 14 & 2.0 & 14/Serial, \(\mu\) P & Int ( +3 V ), Ext & \(\mathbf{N}, \mathbf{P}, \mathbf{Q}\) & C, I, M/w & CMOS, 14-Bit Complete DAC, Parallel or Serial Load & 3-209 \\
\hline AD7849 & 14/16 & 7 (max) & Serial, \(\mu \mathrm{P}\) & Ext (M) & \(\mathbf{N}, \mathbf{Q}, \mathbf{R}\) & I, M & High Accuracy Multiplying DAC, Serial Input & 3-221 \\
\hline AD766 & 16 & 1.5 & Serial, \(\mu \mathrm{P}\) & Int & D, N & C, I, M & Zero-Chip Interface 16-Bit DSP DACPORT & 3-83 \\
\hline AD1851 & 16 & 1.5 & Serial, \(\mu \mathrm{P}\) & Int & N, R & C & 16-Bit, \(16 \times \mathrm{F}_{\text {S }}\) PCM Audio DAC & CI 2-173 \\
\hline AD760 & 16 & 8 & 8/Serial, \(\mu \mathrm{P}\) & Int ( +10 V ), Ext & \(\mathbf{N}, \mathbf{P}, \mathbf{Q}\) & I, M & 16-Bit Self-Calibrating High Accuracy DACPORT & 3-71 \\
\hline AD569 & 16 & 3.0 & 8/16, \(\mu \mathrm{P}\) & \(\pm 5 \mathrm{~V}, \mathrm{Ext}(\mathrm{M})\) & D, N & I, M & Monolithic, 16-Bit Monotonic DAC & 3-38 \\
\hline AD7846 & 16 & 6 & 16, \(\mu \mathrm{P}\) & Ext (M) & D, E, N, P & C, I, M/D & CMOS, 16-Bit Multiplying DAC with Readback Capability & 3-217 \\
\hline AD660 & 16 & 8 & Serial, 8 & 10 V , Int & \(\mathbf{N}, \mathbf{Q}, \mathbf{R}\) & I, M & Monolithic, Complete Serial/Byte I/P 16-Bit DAC & 3-42 \\
\hline AD669 & 16 & 8 & 16, \(\mu \mathrm{P}\) & 10 V , Int & \(\mathbf{N}, \mathbf{Q}, \mathbf{R}\) & I, M & Monolithic, Complete 16-Bit DAC & 3-67 \\
\hline AD1861 & 18 & 1.5 & Serial & Int & N, R & C & 18-Bit, \(16 \times \mathrm{F}_{\text {S }}\) PCM Audio DAC & CI 2-173 \\
\hline AD1139 & 18 & 40 & 18, \(\mu \mathrm{P}\) & -10 V, Int & D & C & True 18-Bit Accuracy & CI 2-167 \\
\hline
\end{tabular}
 bits) and is microprocessor compatible.
 reference is pinned out.



 temperature designator will be followed by: / to indicate \(883 \mathrm{~B},{ }_{\mathrm{J}}\) for JAN, \({ }_{\mathrm{D}}\) for SMD, and \({ }_{5}\) for space level
\({ }^{5}\) CI = Data Converter Reference Manual, Volume I; CII = Data Converter Reference Manual, Volume II. All other entries refer to this volume.
Boldface type: data sheet information in this volume.
DACPORT is a registered trademark of Analog Devices, Inc.

\section*{Selection Guides—Digital-to-Analog Converters}

\section*{Single DACs, Current Output}


\begin{tabular}{ll} 
Comments & Page \(^{5}\) \\
\(\mathbf{3 2}\) MSPS, 16-Bit, Low Glitch for Waveform Synthesis & \(3-89\) \\
16-Bit \(16 \times \mathrm{F}_{\mathrm{S}}\) PCM Audio DAC & CI 2-173 \\
16-Bit High Speed Multiplying DAC & \(\mathbf{3 - 2 9 3}\) \\
Complete Digital to 4-20 mA Loop Controller & 3-15 \\
18-Bit \(16 \times \mathrm{F}_{\mathrm{S}}\) PCM Audio DAC & CI 2-173 \\
20-Bit Audio DAC & CI 2-203
\end{tabular}
\({ }^{1}\) This column lists the data format for the bus with " \(\mu \mathrm{P}\) " indicating microprocessor capability-i.e., for a 12 -bit converter \(8 / 12, \mu \mathrm{P}\) indicates that the data can be formatted for an 8 -bit bus or can be in parallel ( 12 bits) and is microprocessor compatible.
\({ }^{\text {Ent }}\) Ext indicates external reference with the range of voltages listed where applicable. Ext ( \(M\) ) indicates external reference with multiplying capability. Int indicates reference is internal. A voltage value is given if the reference is pinned out.
\({ }^{3}\) Package Options: D = Hermetic DIP, Ceramic or Metal; E = Ceramic Leadless Chip Carrier; F = Ceramic Flatpack; G = Ceramic Pin Grid Array; H = Hermetic Metal Can; J = J-Leaded Ceramic Package; M = Hermetic Metal Can DIP; N = Plastic or Epoxy Sealed DIP; P = Plastic Leaded Chip Carrier; Q = Cerdip; R = Small Outline "SOIC" Package; RS = SSOP-Shrink Small Outline Package; S = Plastic Quad Flatpack; ST \(=\) Thin Quad Flatpack; \(\mathrm{T}=\mathrm{TO}-92 ; \mathrm{U}=\mathrm{TSOP}-\) Thin Small Outline Package; \(\mathrm{W}=\) Nonhermetic Ceramic/Glass DIP; \(\mathrm{Y}=\) Single-In-Line "SIP" Package; \(\mathrm{Z}=\) Ceramic Leaded Chip Carrier \({ }^{4}\) Temperature Ranges: \(\mathrm{C}=\) Commercial, \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C} ; \mathrm{I}=\) Industrial, \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) (Some older products \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) ); \(\mathrm{M}=\) Military, \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\). If a device has military grade offerings, the M temperature designator will be followed by: / to indicate 883B, \({ }_{J}\) for JAN, \({ }_{D}\) for SMD, and \({ }_{s}\) for space level.
\({ }^{5} \mathrm{CI}=\) Data Converter Reference Manual, Volume I; D = Data Sheet. All other entries refer to this volume.
Boldface Type: Data sheet information in this volume.

\section*{Selection Guides—Digital-to-Analog Converters}

\section*{Multiple DACs, Voltage Output}
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline Model & Res Bits & Settling Time \(\mu \mathrm{styp}\) & \begin{tabular}{l}
Bus \\
Interface \\
Bits \({ }^{1}\)
\end{tabular} & \begin{tabular}{l}
Reference \\
Voltage \\
\(\operatorname{Int} /\) Ext \(^{2}\)
\end{tabular} & \# of DACs & Package Options \({ }^{3}\) & Temp Ranges \({ }^{4}\) & Comments & Page \({ }^{5}\) \\
\hline AD7669 & 8 & 1.0 & 8, \(\mu \mathrm{P}\) & Int & 2 & N, P, R & C, I, M & CMOS, Complete 8-Bit Dual DAC/ADC/SHA/Reference & CII 8-7 \\
\hline AD8600 & 8 & 2 & 8, \(\mu \mathrm{P}\) & Ext, 2.5 V & 16 & P & I & 16-Channel, 8-Bit Multiplying DAC & 3-253 \\
\hline DAC8229 & 8 & 2.0 & 8, \(\mu \mathrm{P}\) & Ext (M) & 2 & \(\mathbf{N}, \mathbf{P}, \mathbf{R}\) & I, M/ & CMOS, Single or Dual Supply Operation & 3-322 \\
\hline AD7769 & 8 & 2.5 & 8, \(\mu \mathrm{P}\) & Ext & 2 & N, P & C, I & \begin{tabular}{l}
CMOS, Complete 8-Bit Dual DAC/ \\
2-Channel ADC
\end{tabular} & CII 8-27 \\
\hline DAC8426 & 8 & 3.0 & 8, \(\mu \mathrm{P}\) & 10 V , Int & 4 & \(\mathbf{N}, \mathbf{Q}, \mathbf{R}\) & I, M & CMOS, Complete with 10 V Reference, Improved Timing & 3-352 \\
\hline PM7226A & 8 & 3.0 & 8, \(\mu \mathrm{P}\) & Ext (M) & 4 & N, Q, R & I, M & CMOS, Improved Timing, Specified for +5 V to +15 V Operation & CI 2-303 \\
\hline AD7226 & 8 & 3.0 & 8, \(\mu \mathrm{P}\) & 2-12.5 V, Ext & 8 & \(\mathbf{E}, \mathbf{N}, \mathbf{P}, \mathbf{Q}, \mathbf{R}\) & C, I, M/D & CMOS, No User Trims, Specified with Single or Dual Supplies & 3-115 \\
\hline AD7225 & 8 & 5.0 (max) & 8, \(\mu \mathrm{P}\) & 2-12.5 V, Ext & 4 & \(\mathbf{E}, \mathbf{N}, \mathbf{P}, \mathbf{Q}, \mathbf{R}\) & C, I, M/D & CMOS, Separate References for Each DAC & 3-111 \\
\hline DAC8800 & 8 & 0.8 & 8, Serial & DC, Ext & 8 & \(\mathbf{N}, \mathbf{Q}, \mathbf{R}\) & C, I, M/ & Octal 8-Bit CMOS DAC (TrimDAC®) & 3-390 \\
\hline DAC8840 & 8 & 3.5 & Serial & Ext (M) & 8 & \(\mathbf{N}, \mathbf{Q}, \mathbf{R}\) & I, M & CMOS, Four-Quadrant Multiplying TrimDACs with Op Amps, 8 Channel & 3-393 \\
\hline DAC8841 & 8 & 3.5 & Serial & Ext (M) & 8 & N, Q, R & I, M & Octal 8-Bit, Two Quadrant, Multiplying TrimDAC, +5 V Operation & CI 2-1131 \\
\hline AD7228A & 8 & 5.0 (max) & 8, \(\mu \mathrm{P}\) & 2-10 V, Ext & 8 & \(\mathbf{N}, \mathbf{P}, \mathbf{Q}, \mathbf{R}\) & C, I, M & CMOS, Specified for Single or Dual Supply, 5 V to 15 V Skinny 24-Pin SOP/DIP & 3-119 \\
\hline DAC8228 & 8 & 2 & 8, \(\mu \mathrm{P}\) & Ext (M) & 2 & \(\mathbf{N}, \mathbf{Q}, \mathbf{R}\) & I & Dual 8-Bit Multiplying DAC & 3-318 \\
\hline AD8842 & 8 & 4 & Serial, \(\mu \mathrm{P}\) & Ext (M) & 8 & N, R & I & Octal 8-Bit Multiplying TrimDAC & 3-257 \\
\hline AD75004 & 12 & 2 & 8, \(\mu \mathrm{P}\) & 5 V , Int & 4 & N, P & C & Fastest Quad 12-Bit Voltage Output DACPORT & 3-281 \\
\hline AD7242 & 12 & 2 & Serial, \(\mu \mathrm{P}\) & 3 V , Int & 2 & \(\mathbf{N}, \mathbf{Q}, \mathbf{R}\) & C, I & Complete \(\pm 5\) V 12-Bit Dual DAC & 3-133 \\
\hline AD390 & 12 & 4 & 12, \(\mu \mathrm{P}\) & 10 V , Int & 4 & D & C, \(\mathrm{M} / \mathrm{D}\) & Double Buffered, Simultaneous Update & CI 2-23 \\
\hline AD7249 & 12 & 10 (max) & Serial, \(\mu \mathrm{P}\) & Int (+5 V), Ext & 2 & \(\mathbf{N}, \mathbf{Q}, \mathbf{R}\) & I, M & Complete 12-Bit Dual DAC, Serial Input & 3-147 \\
\hline AD7837 & 12 & 5 & 8, \(\mu \mathrm{P}\) & Ext (M) & 2 & \(\mathbf{N}, \mathbf{Q}, \mathbf{R}\) & C, I, M & CMOS, MDAC, Byte Load, Double Buffered & 3-205 \\
\hline AD7847 & 12 & 5 & 12, \(\mu \mathrm{P}\) & Ext (M) & 2 & \(\mathbf{N}, \mathbf{Q}, \mathbf{R}\) & C, I, M & CMOS, MDAC, Parallel Load & 3-205 \\
\hline DAC8412 & 12 & 6 & 12, \(\mu \mathrm{P}\) & Ext & 4 & \(\mathbf{D}, \mathbf{E}, \mathbf{N}, \mathbf{P}, \mathbf{Q}\) & I, M/ & Readback, Reset to Midscale, Low Power Quad DAC, \(\mathbf{+ 5}\) V to \(\pm \mathbf{1 5}\) V Operation & 3-333 \\
\hline DAC8413 & 12 & 6 & 12, \(\mu \mathrm{P}\) & Ext & 4 & D, E, N, P, Q & I, M/ & Equivalent to DAC8412 with Reset to Zero Scale & 3-337 \\
\hline DAC8420 & 12 & 6 & Serial & Ext & 4 & \(\mathbf{N}, \mathbf{Q}, \mathbf{R}\) & I, M & BiCMOS, Equivalent to 8412/8413 with Serial Interface in 16-Pin Package & 3-337 \\
\hline AD75089 & 12 & 8 & 12 & 5 V , Int & 8 & P & C & Monolithic Octal 12-Bit Voltage Output DACPORT & CI 2-777 \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline Model & Res Bits & Settling Time \(\mu \mathrm{s}\) typ & Bus Interface Bits \({ }^{1}\) & \begin{tabular}{l}
Reference \\
Voltage \\
Int/Ext \({ }^{2}\)
\end{tabular} & \[
\begin{aligned}
& \text { \# of } \\
& \text { DACs }
\end{aligned}
\] & Package Options \({ }^{3}\) & \begin{tabular}{l}
Temp \\
Ranges \({ }^{4}\)
\end{tabular} & Comments & Page \({ }^{5}\) \\
\hline AD7237A & 12 & 10 (max) & 8, \(\mu \mathrm{P}\) & Int ( +5 V ), Ext & 2 & \(\mathbf{N}, \mathbf{Q}, \mathbf{R}\) & C, I & CMOS, Complete 12-Bit Dual DAC, 12 V-15 V Supplies & 3-127 \\
\hline AD7247A & 12 & 10 (max) & 12, \(\mu \mathrm{P}\) & Int ( +5 V ), Ext & 2 & \(\mathbf{N}, \mathbf{Q}, \mathbf{R}\) & C, I & Same as AD7237A, Except 8+4 Interface & 3-127 \\
\hline AD8522 & 12 & 16 & Serial, \(\mu \mathrm{P}\) & Int (+2.5 V) & 2 & N, R & I & Complete 12-Bit Dual DAC, 5 V Supply, Serial & 3-241 \\
\hline AD8582 & 12 & 16 & 12, \(\mu \mathrm{P}\) & Int (+2.5 V) & 2 & N, R & I & Complete 12-Bit Dual DAC, 5 V Supply, Parallel & 3-245 \\
\hline AD664 & 12 & 10 & 12, \(\mu \mathrm{P}\) & Ext (M) & 4 & D, E, N, P & C, \(\mathrm{I}, \mathrm{M} / \mathrm{D}\) & Readback, Reset, Low Power Quad DAC & 3-54 \\
\hline AD394 & 12 & 10 & 12, \(\mu \mathrm{P}\) & Ext (M) & 4 & D & C, \(M /{ }_{D}\) & Four Independent Reference Inputs, Bipolar Outputs & CI 2-31 \\
\hline AD7244 & 14 & 2 & Serial, \(\mu \mathrm{P}\) & +3 V, Int & 2 & \(\mathbf{N}, \mathbf{Q}, \mathbf{R}\) & C, I, M & Complete \(\pm 5\) V 14-Bit Dual DAC & 3-107 \\
\hline AD1866 & 16 & 1.5 & Serial & Int & 2 & N, R & I & Dual 16-Bit Audio DAC, +5 V Single Supply & CI 2-235 \\
\hline AD1865 & 18 & 1.5 & Serial & Int & 2 & N, R & C & Dual 18-Bit, \(16 \times \mathrm{F}_{\text {S }}\) PCM Audio DAC & CI 2-225 \\
\hline AD1868 & 18 & 1.5 & Serial & Int & 2 & N, R & C & Dual 18-Bit Audio DAC, +5 V Single Supply & CI 2-237 \\
\hline
\end{tabular}
 bits) and is microprocessor compatible.
 reference is pinned out.



 temperature designator will be followed by: / to indicate 883B, for JAN, \({ }_{\mathrm{D}}\) for SMD, and \({ }_{\mathrm{s}}\) for space level.
\({ }^{5}\) CI = Data Converter Reference Manual, Volume I; CII = Data Converter Reference Manual, Volume II. All other entries refer to this volume.
Boldface type: Data sheet information in this volume.
TrimDAC is a registered trademark of Analog Devices, Inc.

\section*{Selection Guides—Digital-to-Analog Converters}

\section*{Multiple DACs, Current Output}
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline Model & Res Bits & Settling Time \(\mu \mathrm{s}\) typ & \begin{tabular}{l}
Bus \\
Interface \\
Bits \({ }^{1}\)
\end{tabular} & \begin{tabular}{l}
Reference \\
Voltage \\
Int/Ext \({ }^{2}\)
\end{tabular} & \begin{tabular}{l}
\# of \\
DACs
\end{tabular} & Package Options \({ }^{3}\) & Temp Ranges \({ }^{4}\) & Comments & Page \({ }^{5}\) \\
\hline AD7528 & 8 & 0.18 & 8, \(\mu \mathrm{P}\) & Ext (M) & 2 & \(\mathbf{E}, \mathbf{N}, \mathbf{P}, \mathbf{Q}, \mathbf{R}\) & C, I, M/D & CMOS, +5 V to +15 V Operation, TTL Compatible at \(\mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V}\) & 3-163 \\
\hline DAC8408 & 8 & 0.19 & 8, \(\mu \mathrm{P}\) & Ext (M) & 4 & \(\mathbf{N}, \mathbf{P}, \mathbf{Q}, \mathbf{R}\) & C, \(\mathrm{I}, \mathrm{M} /{ }_{\mathrm{D}}\) & CMOS, Data Readback Memory Function, Separate \(\mathbf{V}_{\text {REF }}\) & 3-329 \\
\hline PM7628 & 8 & 0.20 & 8, \(\mu \mathrm{P}\) & Ext (M) & 2 & E, N, P, Q, R & I, M/ & CMOS, +5 V or +15 V Operation, Improved Timing & CI 2-665 \\
\hline AD7628 & 8 & 0.35 & 8, \(\mu \mathrm{P}\) & Ext (M) & 2 & \(\mathbf{E}, \mathbf{N}, \mathbf{P}, \mathbf{Q}, \mathbf{R}\) & C, I, M/ & CMOS, +12 V to +15 V Operation, TTL Compatible at \(\mathrm{V}_{\mathrm{DD}}=12 \mathrm{~V}\) to 15 V & 3-191 \\
\hline DAC8221 & 12 & 0.45 & 12, \(\mu \mathrm{P}\) & Ext (M) & 2 & \(\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}\) & C, \(\mathrm{I}, \mathrm{M} / \mathrm{DS}\) & CMOS, Buffered Inputs, +5 V Operation & 3-311 \\
\hline AD7568 & 12 & 0.2 & Serial, \(\mu \mathbf{P}\) & Ext (M) & 8 & P, S & I & Single +5 V Supply, Separate References, 44-Pin PQFP and PLCC & 3-185 \\
\hline AD7564 & 12 & 0.5 & Serial, \(\mu \mathrm{P}\) & Ext (M) & 4 & N, R & I & Quad 12-Bit Multiplying DAC, 5 V Supply & 3-177 \\
\hline DAC8222 & 12 & 1.0 (max) & 12, \(\mu \mathrm{P}\) & Ext (M) & 2 & \(\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}\) & C, \(\mathbf{I}, \mathrm{M} /{ }_{\text {ds }}\) & CMOS, Double Buffered Inputs, Parallel Load & 3-315 \\
\hline DAC8248 & 12 & 1.0 (max) & 8, \(\mu \mathrm{P}\) & Ext (M) & 2 & \(\mathbf{N}, \mathbf{Q}, \mathbf{R}\) & C, I, M/ & CMOS, Double Buffered Inputs, Byte Load & 3-325 \\
\hline AD7537 & 12 & 1.5 (max) & 8, \(\mu \mathrm{P}\) & Ext (M) & 2 & \(\mathbf{E}, \mathbf{N}, \mathbf{P}, \mathbf{Q}, \mathbf{R}\) & \(\mathbf{C}, \mathbf{I}, \mathrm{M} /{ }_{\mathbf{D}}\) & CMOS, Byte Load, Double Buffered & 3-167 \\
\hline AD7547 & 12 & 1.5 (max) & 12, \(\mu \mathrm{P}\) & Ext (M) & 2 & \(\mathbf{E}, \mathbf{N}, \mathbf{P}, \mathbf{Q}, \mathbf{R}\) & C, \(\mathbf{I}, \mathrm{M} / \mathrm{D}\) & CMOS, Parallel Load & 3-167 \\
\hline AD7549 & 12 & 1.5 (max) & 4, \(\mu \mathrm{P}\) & Ext (M) & 2 & E, N, P, Q & C, \(\mathrm{I}, \mathrm{M} / \mathrm{D}_{\mathrm{D}}\) & CMOS, Nibble Load, Double Buffered & CI 2-629 \\
\hline AD1865 & 18 & - \(\because\) & Serial, \(\mu \mathrm{P}\) & Int & 2 & N & C & Dual 18-Bit, \(16 \times \mathrm{F}_{\text {S }}\) PCM Audio DAC & CI 2-225 \\
\hline
\end{tabular}

LOGDACs \({ }^{\circledR}\)
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline Model & \begin{tabular}{l}
Res \\
dB
\end{tabular} & Full-Scale Range dB & \begin{tabular}{l}
Accuracy \\
dB
\end{tabular} & Package Options \({ }^{3}\) & Temp Ranges \({ }^{4}\) & Comments & Page \({ }^{5}\) \\
\hline AD7111 & 0.375 & 88.5 & 0.17 & \(\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}\) & C, I, M/ & Low Distortion & 3-93 \\
\hline AD7111A & 0.375 & 88.5 & 0.17 & N, \(\mathbf{R}\) & I & Low Glitch, Pin Compatible with AD7524 & 3-93 \\
\hline AD7112 & 0.375 & 88.5 & 0.17 & N, R & I & Low Glitch, Pin Compatible with AD7528 & 3-99 \\
\hline AD7118 & 1.5 & 88.5 & 0.35 & E, N, P, Q, R & C, I, M/ & CMOS & CI 2-253 \\
\hline
\end{tabular}

\footnotetext{
 bits) and is microprocessor compatible.
 reference is pinned out.
\({ }^{3}\) Package Options: D = Hermetic DIP, Ceramic or Metal; E = Ceramic Leadless Chip Carrier; F = Ceramic Flatpack; G = Ceramic Pin Grid Array; H = Hermetic Metal Can; J = J-Leaded Ceramic Package;


 temperature designator will be followed by: / to indicate 883 B, , for JAN, \({ }_{\mathrm{D}}\) for SMD, and \({ }_{\mathrm{s}}\) for space level.
\({ }^{5} \mathrm{CI}=\) Data Converter Reference Manual, Volume I. All other entries refer to this volume.
Boldface Type: Data sheet information in this volume.
LOGDAC is a registered trademark of Analog Devices, Inc.
}

\section*{FEATURES}

\author{
4-20 mA, 0-20 mA or 0-24 mA Current Output 16-Bit Resolution and Monotonicity \(\pm 0.012 \%\) max Integral Nonlinearity \(\pm 0.05 \%\) max Offset (Trimmable) \(\pm \mathbf{0 . 1 5 \%}\) max Total Output Error (Trimmable) \\ Flexible Serial Digital Interface (3.3 Mbps) On-Chip Loop Fault Detection On-Chip 5 V Reference ( \(25 \mathrm{ppm} /{ }^{\circ} \mathrm{C}\) max) Asynchronous CLEAR Function Power Supply Range of 12 V-36 V Output Loop Compliance of \(0 \mathrm{~V}-33.5 \mathrm{~V}\) 24-Pin SOIC and PDIP Packages
}

\section*{PRODUCT DESCRIPTION}

The AD420 is a complete digital to current loop output converter, designed to meet the needs of the industrial control market. It provides a high precision, fully integrated, low cost single-chip solution for generating current loop signals, in a compact 24 -pin SOIC or PDIP package.
The output current range can be programmed to \(4-20 \mathrm{~mA}\), \(0-20 \mathrm{~mA}\) or an overrange function of \(0-24 \mathrm{~mA}\). The AD420 can alternatively provide a voltage output from a separate pin that can be configured to provide \(0 \mathrm{~V}-5 \mathrm{~V}, 0 \mathrm{~V}-10 \mathrm{~V}, \pm 5 \mathrm{~V}\) or \(\pm 10 \mathrm{~V}\) with the addition of a single external buffer amplifier.
The 3.3M Baud serial input logic design minimizes the cost of galvanic isolation and allows for simple connection to commonly used microprocessors. It can be used in three-wire or asynchronous mode and a serial-out pin is provided to allow daisy chaining of multiple DACs on the current loop side of the isolation barrier.
The AD420 uses sigma-delta ( \(\Sigma \Delta\) ) DAC technology to achieve 16 -bit monotonicity at very low cost. Full-scale settling to \(0.1 \%\) occurs within 3 ms . The only external components that are required (in addition to normal transient protection circuitry) are three low cost capacitors which are used in the DAC output filter.
If the AD420 is going to be used at extreme temperatures and supply voltages, an external output transistor can be used to minimize power dissipation on the chip via the "BOOST" pin.
The FAULT DETECT pin signals when an open circuit occurs in the loop. The on-chip voltage reference can be used to supply a precision +5 V to external components in addition to the AD420 or, if the user desires temperature stability exceeding \(25 \mathrm{ppm} /{ }^{\circ} \mathrm{C}\), an external precision reference such as the AD586 can be used as the reference.
The AD420 is available in a 24 -pin SOIC and PDIP over the industrial temperature range of \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\).

\section*{FUNCTIONAL BLOCK DIAGRAM}


\section*{PRODUCT HIGHLIGHTS}
1. The AD420 is a single chip solution for generating \(4-20 \mathrm{~mA}\) or \(0-20 \mathrm{~mA}\) signals at the "controller end" of the current loop.
2. The AD420 operates on +12 V to +36 V supplies, with an output loop compliance of 0 V to \(\mathrm{V}_{\mathrm{CC}}-2.5 \mathrm{~V}\).
3. The flexible serial input can be used in Three-Wire Mode with SPI^ or MICROWIRE \(\dagger\) microcontrollers, or in Asynchronous Mode which minimizes the number of control signals required.
4. The Serial Data Out pin can be used to daisy chain any number of AD420s together in Three-Wire Mode.
5. At Power-Up the AD420 initializes its output to the low end of the selected range.
6. The AD420 has an asynchronous CLEAR pin which sends the output to the low end of the selected range \((0 \mathrm{~mA}, 4 \mathrm{~mA}\), or 0 V ).
7. The AD420 BOOST pin accommodates an external transistor to off-load power dissipation from the chip.
8. The offset of \(\pm 0.05 \%\) and total output error of \(\pm 0.15 \%\) can be trimmed if desired, using two external potentiometers.
*SPI is a registered trademark of Motorola.
\(\dagger\) MICROWIRE is a registered trademark of National Semiconductor.

\begin{tabular}{|c|c|c|c|c|}
\hline Parameter & Min & \[
\begin{gathered}
\text { AD420AN/AF } \\
\text { Typ }
\end{gathered}
\] & Max & Units \\
\hline RESOLUTION & 16 & & & Bits \\
\hline \begin{tabular}{l}
ACCURACY \({ }^{1}\) \\
Monotonicity Integral Nonlinearity Offset ( 0 mA or 4 mA ) \(\left(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right)\) Offset Drift Total Output Error ( 20 mA or 24 mA ) ( \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) ) Total Output Error Drift PSRR \({ }^{2}\)
\end{tabular} & 16 & \[
\begin{aligned}
& \pm 0.002 \\
& 20 \\
& 20 \\
& 5
\end{aligned}
\] & \[
\begin{aligned}
& \pm 0.012 \\
& \pm 0.05 \\
& 50 \\
& \pm 0.15 \\
& 50 \\
& 10
\end{aligned}
\] & Bits
\(\%\)
\(\%\)
\(\mathrm{ppm} /{ }^{\circ} \mathrm{C}\)
\(\%\)
\(\mathrm{ppm} /{ }^{\circ} \mathrm{C}\)
\(\mu \mathrm{C} / \mathrm{V}\) \\
\hline \begin{tabular}{l}
OUTPUT CHARACTERISTICS \\
Operating Current Ranges \\
Current Loop Voltage Compliance \({ }^{3}\) \\
Output Voltage Range (Pin 17) \\
Settling Time (to \(0.1 \%\) of FS) \({ }^{4}\) \\
Output Impedance (Current Mode)
\end{tabular} & \[
\begin{aligned}
& 4 \\
& 0 \\
& 0 \\
& 0
\end{aligned}
\] & \[
\begin{aligned}
& 2.5 \\
& 25
\end{aligned}
\] & \[
\begin{aligned}
& 20 \\
& 20 \\
& 24 \\
& \mathrm{~V}_{\mathrm{cc}}-2.5 \mathrm{~V} \\
& 5 \\
& 3
\end{aligned}
\] & \begin{tabular}{l}
mA \\
mA \\
mA \\
V \\
V \\
ms \\
\(M \Omega\)
\end{tabular} \\
\hline \begin{tabular}{l}
VOLTAGE REFERENCE \\
REF OUT \\
Output Voltage ( \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) ) \\
Drift \\
Externally Available Current \\
Short Circuit Current \\
REFIN \\
Resistance \\
\(V_{\text {LL }}\) \\
Output Voltage \\
Externally Available Current \\
Short Circuit Current
\end{tabular} & 4.995 & \[
\begin{aligned}
& 5.0 \\
& 5 \\
& 7 \\
& 30 \\
& 4.5 \\
& 5 \\
& 20
\end{aligned}
\] & \[
\begin{aligned}
& 5.005 \\
& \pm 25
\end{aligned}
\] & \begin{tabular}{l}
V \\
\(\mathrm{ppm} /{ }^{\circ} \mathrm{C}\) \\
mA \\
mA \\
\(\mathrm{k} \Omega\) \\
V \\
mA \\
mA
\end{tabular} \\
\hline ```
DIGITAL INPUTS
    \(\mathrm{V}_{\mathrm{IH}}\) (Logic 1)
    \(\mathrm{V}_{\mathrm{IL}}\) (Logic 0)
    \(\mathrm{I}_{\mathrm{IH}}\left(\mathrm{V}_{\mathrm{IN}}=5.0 \mathrm{~V}\right)\)
    \(\mathrm{I}_{\mathrm{IL}}\left(\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}\right)\)
    Data Input Rate ("3-Wire" Mode)
    Data Input Rate ("Asynchronous" Mode)
``` & \begin{tabular}{l}
2.4 \\
No Minimum No Minimum
\end{tabular} & & \[
\begin{aligned}
& 0.8 \\
& \pm 10 \\
& \pm 10 \\
& 3.3 \\
& 150
\end{aligned}
\] & \begin{tabular}{l}
V \\
V \\
\(\mu \mathrm{A}\) \\
\(\mu \mathrm{A}\) \\
Mbps \\
kbps
\end{tabular} \\
\hline ```
DIGITAL OUTPUTS
    FAULT DEFECT
        \(\mathrm{V}_{\mathrm{OH}}\left(10 \mathrm{k} \Omega\right.\) Pull-Up Resistor to \(\left.\mathrm{V}_{\mathrm{LL}}\right)\)
        \(\mathrm{V}_{\mathrm{OL}}\left(10 \mathrm{k} \Omega\right.\) Pull-Up Resistor to \(\left.\mathrm{V}_{\mathrm{LL}}\right)\)
        \(\mathrm{V}_{\mathrm{OL}} @ 2.5 \mathrm{~mA}\)
    DATA OUT
        \(\mathrm{V}_{\mathrm{OH}}\left(\mathrm{I}_{\mathrm{OH}}=-0.8 \mathrm{~mA}\right)\)
        \(\mathrm{V}_{\mathrm{OL}}\left(\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}\right)\)
``` & \[
3.6
\]
\[
3.6
\] & \[
\begin{aligned}
& 4.5 \\
& 0.2 \\
& 0.6 \\
& 4.3 \\
& 0.3
\end{aligned}
\] & \[
\begin{aligned}
& 0.4 \\
& 0.4
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{~V} \\
& \mathrm{~V} \\
& \mathrm{~V} \\
& \mathrm{~V}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
POWER SUPPLY \\
Operating Range \(\mathbf{V}_{\mathrm{CC}}\) \\
Quiescent Current Quiescent Current (External \(\mathrm{V}_{\mathrm{LL}}\) )
\end{tabular} & 12 & \[
\begin{aligned}
& 4.2 \\
& 3
\end{aligned}
\] & \[
\begin{aligned}
& 36 \\
& 5.0
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{~mA} \\
& \mathrm{~mA}
\end{aligned}
\] \\
\hline TEMPERATURE RANGE Specified Performance & -40 & & +85 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Total Output Error includes Offset and Gain Error. Total Output Error and Offset Error are with respect to the Full-Scale Output and are measured with an ideal +5 V reference. If the internal reference is used, the reference errors must be added to the Offset and Total Output Errors.
\({ }^{2} \mathrm{PSRR}\) is measured by varying \(\mathrm{V}_{\mathrm{Cc}}\) from 12 V to 36 V .
\({ }^{3}\) When \(\mathrm{V}_{\mathrm{CC}}\) is greater than 32 V the Minimum \(\mathrm{R}_{\mathrm{L}}\) is \(200 \Omega\).
\({ }^{4}\) External capacitor selection must be as described in Figure 5.
Specifications subject to change without notice.

ABSOLUTE MAXIMUM RATINGS*
V \({ }_{\text {CC }}\) to GND . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 36 V
IOUT to GND . . . . . . . . . . . . . . . . . . . . . . . . . . . . . V \({ }_{\text {CC }}\)
Digital Inputs to GND . . . . . . . . . . . . . . . -0.5 V to +7 V
Digital Outputs to GND . . . . . . . . -0.5 V to \(\mathrm{V}_{\mathrm{LL}}+0.3 \mathrm{~V}\)
\(\mathrm{V}_{\mathrm{LL}}\) and REFOUT: Outputs safe for indefinite short to ground.
Storage Temperature . . . . . . . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Lead Temperature (Soldering, 10 sec ) . . . . . . . . . . . \(+300^{\circ} \mathrm{C}\)
Thermal Impedance:
\begin{tabular}{|c|c|}
\hline SOIC (R) Package & W \\
\hline PDIP (N) Package & \(50^{\circ} \mathrm{C} / \mathrm{W}\) \\
\hline
\end{tabular}
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any conditions above those indicated in the operational specification is not implied. Exposure to absolute maximum specifications for extended periods may affect device reliability.

\section*{ORDERING GUIDE}
\begin{tabular}{l|l|l|l}
\hline Model & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & Description & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD420AN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 24-Pin Plastic DIP & N-24 \\
AD420AR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 24-Pin SOIC & R-24 \\
\hline
\end{tabular}
*For outline information see Package Information section.

\section*{PIN DESIGNATIONS}



Figure 1. Functional Block Diagram

Table I. Truth Table
\begin{tabular}{l|l|l|l}
\hline \multicolumn{3}{c|}{ Inputs } & \\
\hline CLEAR & \begin{tabular}{l} 
Range \\
Select 2
\end{tabular} & \begin{tabular}{l} 
Range \\
Select 1
\end{tabular} & Operation \\
\hline 0 & X & X & Normal Operation \\
1 & X & X & Output at Bottom of Span \\
\hline X & 0 & 0 & 0 V-5 V Range \\
X & 0 & 1 & \(4-20 \mathrm{~mA}\) Range \\
X & 1 & 0 & \(0-20 \mathrm{~mA}\) Range \\
X & 1 & 1 & \(0-24 \mathrm{~mA}\) Range \\
\hline
\end{tabular}

\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD420 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


Timing Requirements \(\left(\mathrm{I}_{\mathrm{A}}=-40^{\circ} \mathrm{cto}+85^{\circ} \mathrm{C}, \mathrm{V}_{\text {cc }}=+12 \mathrm{Vto}+36 \mathrm{~V}\right)\)

\section*{THREE-WIRE INTERFACE}


Figure 2. Timing Diagram for Three-Wire Interface
Table II. Timing Specification for Three-Wire Interface
\begin{tabular}{l|l|l|l}
\hline Parameter & Label & Limit & Units \\
\hline Data Clock Period & \(\mathrm{t}_{\mathrm{CK}}\) & 300 & ns min \\
Data Clock Low Time & \(\mathrm{t}_{\mathrm{CL}}\) & 80 & ns min \\
Data Clock High Time & \(\mathrm{t}_{\mathrm{CH}}\) & 80 & ns min \\
Data Stable Width & \(\mathrm{t}_{\mathrm{DW}}\) & 125 & ns min \\
Data Setup Time & \(\mathrm{t}_{\mathrm{DS}}\) & 40 & ns min \\
Data Hold Time & \(\mathrm{t}_{\mathrm{DH}}\) & 5 & ns min \\
Latch Delay Time & \(\mathrm{t}_{\mathrm{LD}}\) & 80 & ns min \\
Latch Low Time & \(\mathrm{t}_{\mathrm{LL}}\) & 80 & ns min \\
Latch High Time & \(\mathrm{t}_{\mathrm{LH}}\) & 80 & ns min \\
Serial Output Delay Time & \(\mathrm{t}_{\mathrm{SD}}\) & 225 & ns max \\
Clear Pulse Width & \(\mathrm{t}_{\mathrm{CLR}}\) & 50 & ns min \\
\hline
\end{tabular}


Figure 3. Timing Diagram for Asynchronous Interface
Table III. Timing Specifications for Asynchronous Interface
\begin{tabular}{l|l|l|l}
\hline Parameter & Label & Limit & Units \\
\hline Asynchronous Clock Period & \(\mathrm{t}_{\mathrm{ACK}}\) & 400 & ns min \\
Asynchronous Clock Low Time & \(\mathrm{t}_{\mathrm{ACL}}\) & 50 & ns min \\
Asynchronous Clock High Time & \(\mathrm{t}_{\mathrm{ACH}}\) & 150 & ns min \\
Data Stable Width (Critical Clock Edge) & \(\mathrm{t}_{\mathrm{ADW}}\) & 300 & ns min \\
Data Setup Time (Critical Clock Edge) & \(\mathrm{t}_{\mathrm{ADS}}\) & 50 & ns min \\
Data Hold Time (Critical Clock Edge) & \(\mathrm{t}_{\mathrm{ADH}}\) & 20 & ns min \\
Clear Pulse Width & \(\mathrm{t}_{\mathrm{CLR}}\) & 50 & ns min \\
\hline
\end{tabular}

\section*{ASYNCHRONOUS INTERFACE}

Note in the timing diagram for Asynchronous Mode operation each data word is "framed" by a START (0) bit and a STOP (1) bit. The data timing is with respect to the rising edge of the CLOCK at the center of each bit cell. Bit cells are 16 clocks long, and the first cell (the START bit) begins at the first clock following the leading (falling) edge of the START bit. Thus the MSB (D15) is sampled 24 clock cycles after the beginning of the START bit, D14 is sampled at clock number 40, and so on. During any "dead time" before writing the next word the DATA IN pin must remain at logic 1.
The DAC output updates when the STOP bit is received. In the case of a "framing error" (the STOP bit sampled as a 0 ) the AD420 will output a pulse at the DATA OUT pin one clock period wide during the clock period subsequent to sampling the STOP bit. The DAC output will not update if a "framing error" is detected.

PIN DESCRIPTION
\begin{tabular}{|c|c|c|c|}
\hline Pin \# & Symbol & Type & Function \\
\hline 2 & \(\mathrm{V}_{\text {LL }}\) & P & Auxiliary buffered +4.5 V digital logic voltage. This pin is the internal supply voltage for the digital circuitry and can be used as a termination for pull-up resistors. An external +5 V power supply can be connected to \(\mathrm{V}_{\mathrm{LL}}\). It will override this buffered voltage, thus reducing the internal power dissipation. \\
\hline 3 & FAULT DETECT & DO & FAULT DETECT, connected to a pull-up resistor, is asserted low when the output current does not match the DAC's programmed value. For example, in case the current loop is broken. \\
\hline 4
5 & RANGE SELECT 2 RANGE SELECT 1 & DI & Selects the converters output operating range. One output voltage range and three output current ranges are available. \\
\hline 6 & CLEAR & DI & Valid \(\mathrm{V}_{\mathrm{IH}}\) will unconditionally force the output to go to the minimum of its programmed range. After CLEAR is removed the DAC output will remain at this value. The data in the input register is unaffected. \\
\hline 7 & LATCH & DI & In the three-wire interface mode a rising edge parallel loads the serial input register data into the DAC. To use the asynchronous mode connect LATCH through a current limiting resistor to \(\mathrm{V}_{\mathrm{CC}}\). \\
\hline 8 & CLOCK & DI & Data Clock Input. The clock period is equal to the input data bit rate in the three-wire interface mode and is 16 times the bit rate in asynchronous mode. \\
\hline 9 & DATA IN & DI & Serial Data Input. \\
\hline 10 & DATA OUT & DO & Serial Data Output. In the three-wire interface mode, this output can be used for daisy chaining multiple AD420s. In the asynchronous mode a positive pulse will indicate a framing error after the stop-bit is received. \\
\hline 11 & GND & P & Ground (Common). \\
\hline 14 & REF OUT & AO & +5 V Reference Output. \\
\hline 15 & REF IN & AI & Reference Input. \\
\hline 16 & OFFSET TRIM & AI & Offset Adjust. \\
\hline 17 & \(\mathrm{V}_{\text {OUT }}\) & AO & Voltage Output. \\
\hline 18 & \(\mathrm{I}_{\text {OUT }}\) & AO & Current Output. \\
\hline 19 & BOOST & AO & Connect to an external transistor to reduce the power dissipated in the AD420 output transistor, if desired. \\
\hline 20
21
22 & CAP 1
CAP 2
CAP 3 & AI & These pins are used for internal filtering. Connect capacitors between each of these pins and \(\mathrm{V}_{\mathrm{CC}}\). Refer to the description of current output operation. \\
\hline 23 & \(\mathrm{V}_{\mathrm{cc}}\) & P & +12 V to +36 V Power. \\
\hline 1, 12, 13, 24 & NC & & No Connection. No internal connections inside device. \\
\hline
\end{tabular}

Type: \(\mathrm{AI}=\) Analog Input, \(\mathrm{AO}=\) Analog Output, \(\mathrm{DI}=\) Digital Input, \(\mathrm{DO}=\) Digital Output, \(\mathrm{P}=\) Power

\section*{DEFINITIONS OF SPECIFICATIONS}

RESOLUTION: For 16 -bit resolution, \(1 \mathrm{LSB}=0.0015 \%\) of the FSR. In the \(4-20 \mathrm{~mA}\) range \(1 \mathrm{LSB}=244 \mathrm{nA}\).
INTEGRAL NONLINEARITY: Analog Devices defines integral nonlinearity as the maximum deviation of the actual, adjusted DAC output from the ideal analog output (a straight line drawn from 0 to FS-1 LSB) for any bit combination. This is also referred to as relative accuracy.
DIFFERENTIAL NONLINEARITY: Differential nonlinearity is the measure of the change in the analog output, normalized to full scale, associated with an LSB change in the digital input code. Monotonic behavior requires that the differential linearity error be greater than -1 LSB over the temperature range of interest.
MONOTONICITY: A DAC is monotonic if the output either increases or remains constant for increasing digital inputs with the result that the output will always be a single-valued function of the input.

GAIN ERROR: Gain error is a measure of the output error between an ideal DAC and the actual device output with all 1s loaded after offset error has been adjusted out.
OFFSET ERROR: Offset error is the deviation of the output current from its ideal value expressed as a percentage of the fullscale output with all 0 s loaded in the DAC.
DRIFT: Drift is the change in a parameter (such as gain and offset) over a specified temperature range. The drift temperature coefficient, specified in \(\mathrm{ppm} /{ }^{\circ} \mathrm{C}\), is calculated by measuring the parameter at \(\mathrm{T}_{\text {MIN }}, 25^{\circ} \mathrm{C}\), and \(\mathrm{T}_{\text {MAX }}\) and dividing the change in the parameter by the corresponding temperature change.
CURRENT LOOP VOLTAGE COMPLIANCE: The voltage compliance is the maximum voltage at the IOUT pin for which the output current will be equal to the programmed value.

\section*{THEORY OF OPERATION}

The AD420 uses a sigma-delta ( \(\Sigma \Delta\) ) architecture to carry out the digital-to-analog conversion. This architecture is particularly well suited for the relatively low bandwidth requirements of the industrial control environment because of its inherent monotonicity at high resolution.
In the AD420 a second order modulator is used to keep complexity and die size to a minimum. The single bit stream from the modulator controls a switched current source that is then filtered by three, continuous time resistor-capacitor sections. The capacitors are the only external components that have to be added for standard current-out operation. The filtered current is amplified and mirrored to the supply rail so that the application simply sees a \(4-20 \mathrm{~mA}, 0-20 \mathrm{~mA}\), or \(0-24 \mathrm{~mA}\) current source output with respect to ground. The AD420 is manufactured on a BiCMOS process that is well suited to implementing low voltage digital logic with high performance and high voltage analog circuitry.
The AD420 can also provide a voltage output instead of a current loop output if desired. The addition of a single external amplifier allows the user to obtain \(0 \mathrm{~V}-5 \mathrm{~V}, 0 \mathrm{~V}-10 \mathrm{~V}, \pm 5 \mathrm{~V}\), or \(\pm 10 \mathrm{~V}\).
The AD420 has a loop fault detection circuit that warns if the voltage at IOUT attempts to rise above the compliance range, due to an open loop circuit or insufficient power supply voltage. The FAULT DETECT is an active low open drain signal so that one can connect several AD420s together to one pull-up resistor for global error detection. The pull-up resistor can be tied to the VLL pin, or an external +5 V logic supply.
The IOUT current is controlled by a PMOS transistor and internal amplifier as shown in the functional block diagram. The internal circuitry that develops the fault output avoids using a comparator with "window limits" since this would require an actual output error before the FAULT DETECT output becomes active. Instead, the signal is generated when the internal amplifier in the output stage of the AD420 has less than approximately one volt remaining of drive capability (when the gate of the output PMOS transistor nearly reaches ground). Thus the FAULT DETECT output activates slightly before the compliance limit is reached. Since the comparison is made within the feedback loop of the output amplifier, the output accuracy is maintained by its open loop gain, and no output error occurs before the fault detect output becomes active.
The three-wire digital interface, comprising DATA IN, CLOCK, and LATCH, interfaces to all commonly used serial microprocessors without the addition of any external glue logic. Data is loaded into an input register under control of CLOCK and is loaded to the DAC when LATCH is strobed. If a user wants to minimize the number of galvanic isolators in an intrinsically safe application, the AD420 can be configured to run in "asynchronous" mode. This mode is selected by connecting the LATCH pin to \(\mathrm{V}_{\mathrm{CC}}\) through a current limiting resistor. The data must then be combined with a start and stop bit to "frame" the information and trigger the internal LATCH signal.


Figure 4. Functional Block Diagram

\section*{APPLICATIONS}

\section*{CURRENT OUTPUT}

The AD420 can provide \(4-20 \mathrm{~mA}, 0-20 \mathrm{~mA}\), or \(0-24 \mathrm{~mA}\) output without any active external components. The three capacitors shown in Figure 5 are all that is required. These can be any type of low cost ceramic capacitors. To meet the specified fullscale settling time of 3 ms , low dielectric absorption capacitors ( NPO ) are required. Suitable values are \(\mathrm{Cl}=0.01 \mu \mathrm{~F}, \mathrm{C} 2\) \(=0.01 \mu \mathrm{~F}\), and \(\mathrm{C} 3=0.0033 \mu \mathrm{~F}\).


Figure 5. Standard Configuration

\section*{DRIVING INDUCTIVE LOADS}

When driving inductive or poorly defined loads connect a \(0.01 \mu \mathrm{~F}\) capacitor between IOUT (Pin 18) and GND (Pin 11). This will ensure stability of the AD420 with loads beyond 50 mH . There is no maximum capacitance limit. The capacitive component of the load may cause slower settling, though this may be masked by the settling time of the AD420. A programmed change in the current may cause a back EMF voltage on the output that may exceed the compliance of the AD420. To prevent this voltage from exceeding the supply rails connect protective diodes between IOUT and each of \(\mathrm{V}_{\mathrm{CC}}\) and GND.

\section*{VOLTAGE-MODE OUTPUT}

Since the AD420 is a single supply device, it is necessary to add an external buffer amplifier to the VOUT pin to obtain a selection of high quality bipolar output voltage ranges as shown in Figure 6.


Figure 6.
Table IV. Buffer Amplifier Configuration
\begin{tabular}{l|l|l|l}
\hline R1 & R2 & R3 & VOUT \\
\hline Open & Open & 0 & \(0-5 \mathrm{~V}\) \\
Open & R & R & \(0-10 \mathrm{~V}\) \\
R & Open & R & \(\pm 5 \mathrm{~V}\) \\
R & 2 R & 2 R & \(\pm 10 \mathrm{~V}\) \\
\hline
\end{tabular}

Suitable \(\mathrm{R}=5 \mathrm{k} \Omega\).

\section*{OPTIONAL SPAN AND ZERO TRIM}

For those users who would like lower than specified values of offset and gain error, Figure 7 shows a simple way to trim these parameters. Care should be taken to select low drift resistors because they will affect the temperature drift performance of the DAC.

The adjustment algorithm is iterative. The procedure for trimming the AD420 in the \(4-20 \mathrm{~mA}\) mode can be accomplished as follows:
STEP I . . .OFFSET ADJUST
Load all zeros. Adjust RZERO for 4.00000 mA of output current.
STEP II . . .GAIN ADJUST
Load all ones. Adjust RSPAN for 19.99976 mA (FS - 1 LSB) of output current.
Return to STEP I and iterate until convergence is obtained.


Figure 7. Offset and Gain Adjust

\section*{THREE-WIRE INTERFACE}

Figure 8 shows the AD420 connected in the three-wire interface mode. The AD420 data input block contains a serial input shift register and a parallel latch. The contents of the shift register are controlled by the DATA IN signal and the rising edges of the CLOCK. Upon request of the LATCH pin the DAC and internal latch are updated from the shift register parallel outputs. The CLOCK should remain inactive while the DAC is updated. Refer to the timing requirements for Three-Wire Interface.


Figure 8. Three-Wire Interface Using Multiple DACs with Joint Fault Detect

\section*{USING MULTIPLE DACS WITH FAULT DETECT}

The three-wire interface mode can utilize the serial DATA OUT for easy interface to multiple DACs. To program the two AD420s in Figure 8, 32 data bits are required. The first 16 bits are clocked into the input shift register of DAC1. The next 16 bits transmitted pass the first 16 bits from the DATA OUT pin of DAC1 to the input register of DAC2. The input shift registers of the two DACs operate as a single 32-bit shift register, with the leading 16 bits representing information for DAC2 and the trailing 16 bits serving for DAC1. Each DAC is then updated upon request of the LATCH pin. The daisy-chain can be extended to as many DACs as required.

\section*{ASYNCHRONOUS INTERFACE USING OPTO-COUPLERS}

The AD420 connected in ASYNCHRONOUS INTERFACE mode with opto-couplers is shown in Figure 9. Asynchronous operation minimizes the number of control signals required for isolation of the digital system from the control loop. The resistor connected between the LATCH pin and \(\mathrm{V}_{\mathrm{CC}}\) is required to activate this mode. For operation with \(\mathrm{V}_{\mathrm{CC}}\) below 18 V use a \(50 \mathrm{k} \Omega\) pull-up resistor, from \(18 \mathrm{~V}-36 \mathrm{~V}\) use \(100 \mathrm{k} \Omega\). Asynchronous mode requires that the clock run at 16 times the data bit rate, therefore to operate at the maximum input data rate of 150 kbps an input clock of 2.4 MHz is required. The actual data rate achieved may be limited by the type of opto-couplers chosen. The number of control signals can further be reduced by creating the appropriate clock signal on the current loop side of the isolation barrier.


Figure 9. Asynchronous Interface Using Opto-Couplers

\section*{MICROPROCESSOR INTERFACE SECTION} AD420 TO MC68HC11 (SPI BUS) INTERFACE
The AD420 interface to the Motorola SPI (Serial Peripheral Interface) is shown in Figure 10. The MOSI, SCK, and \(\overline{\text { SS }}\) pins of the HC11 are respectively connected to the DATA IN, CLOCK, and LATCH pins of the AD420. The majority of the interfacing issues are done in the software initialization. A typical routine such as the one shown below begins by initializing the state of the various SPI data and control registers.
\begin{tabular}{llll} 
INIT & LDAA & \#\$2F & ; \(\overline{\text { SS }}=1 ;\) SCK \(=0 ;\) MOSI \(=1\) \\
& STAA & PORTD & ;SEND TO SPI OUTPUTS \\
& LDAA & \#\$38 & ;SS, SCK,MOSI = OUTPUTS \\
& STAA & DDRD & ;SEND DATA DIRECTION INFO \\
& LDAA & \#\$50 & ;DABL INTRPTS,SPI IS MASTER \& ON \\
& STAA & SPCR & ;CPOL = 0, CPHA \(=0,1 M H Z ~ B A U D R A T E ~\) \\
NEXTPT & LDAA & MSBY & ;LOAD ACCUM W/UPPER 8 BITS \\
& BSR & SENDAT & ;JUMP TO DAC OUTPUT ROUTINE \\
& JMP & NEXTPT & ;INFINITE LOOP \\
SENDAT & LDY & \#\$1000 & ;POINT AT ON-CHIP REGISTERS \\
& BCLR & \$08,Y,\$20 & ;DRIVE \(\overline{\text { SS }}\) (LATCH) LOW \\
& STAA & SPDR & ;SEND MS-BYTE TO SPI DATAA REG \\
WAIT1 & LDAA & SPSR & ;CHECK STATUS OF SPIE \\
& BPL & WAIT1 & ;POLL FOR END OF X-MISSION \\
& LDAA & LSBY & ;GET LOW 8 BITS FROM MEMORY \\
& STAA & SPDR & ;SEND LS-BYTE TO SPI DATA REG \\
WAIT2 & LDAA & SPSR & ;CHECK STATUS OF SPIE \\
& BPL & WAIT2 & ;POLL FOR END OF X-MISSION \\
& BSET & \$08,Y,\$20 & ;DRIVE \(\overline{\text { SS HIGH TO LATCH DATA }}\) \\
& RTS & &
\end{tabular}

The SPI data port is configured to process data in 8-bit bytes. The most significant data byte (MSBY) is retrieved from memory and processed by the SENDAT routine. The \(\overline{\mathrm{SS}}\) pin is driven low by indexing into the PORTD data register and clear Bit 5. The MSBY is then sent to the SPI data register where it is automatically transferred to the AD420 internal shift resister. The \(\mathrm{HCl1}\) generates the requisite eight clock pulses with data valid on the rising edges. After the MSBY is transmitted, the least significant byte (LSBY) is loaded from memory and transmitted in a similar fașhion. To complete the transfer, the LATCH pin is driven high when loading the complete 16-bit word into the AD420.


Figure 10. AD420 to \(68 \mathrm{HC11}\) (SPI) Interface

\section*{AD420 TO MICROWIRE INTERFACE}

The flexible serial interface of the AD420 is also compatible with the National Semiconductor MICROWIRE interface. The MICROWIRE interface is used in micro controllers such as the COP400 and COP800 series of processors. A generic interface to use the MICROWIRE interface is shown in Figure 11. The G1, SK, and SO pins of the MICROWIRE interface are respectively connected to the LATCH, CLOCK, and DATA IN pins of the AD420.


Figure 11. AD420 to MICROWIRE Interface

\section*{EXTERNAL BOOST FUNCTION}

The external boost transistor reduces the power dissipated in the AD420 by reducing the current flowing in the on-chip output transistor (dividing it by the current gain of the external circuit). A discrete NPN transistor with a breakdown voltage \(\mathrm{BV}_{\text {CEO }}\), greater than 36 V can be used as shown in Figure 12.


Figure 12. External Boost Configuration
The external boost capability has been developed for those users who may wish to use the AD420, in the SOIC package, at the extremes of the supply voltage, load current, and temperature range. The PDIP package (because of its lower thermal resistance) will operate safely over the entire specified voltage, temperature, and load current ranges without the boost transistor. The plot in Figure 13 shows the safe operating region for both package types. The boost transistor can also be used to reduce the amount of temperature induced drift in the part. This will minimize the temperature induced drift of the on-chip voltage reference, which improves drift and linearity.


Figure 13. Safe Operating Region

\section*{AD420 PROTECTION}

\section*{TRANSIENT VOLTAGE PROTECTION}

The AD420 contains ESD protection diodes which prevent damage from normal handling. The industrial control environment can, however, subject I/O circuits to much higher transients. In order to protect the AD420 from excessively high voltage transients such as those specified in IEC 801, external power diodes and a surge current limiting resistor may be required, as shown in Figure 14. The constraint on the resistor is that during normal operation the output voltage level at IOUT must remain within its voltage compliance limit (IOUT \(\times\left(\mathrm{Rp}+\mathrm{R}_{\text {LOAD }}\right) \leq\) \(\mathrm{V}_{\mathrm{CC}}-2.5 \mathrm{~V}\) ) and the two protection diodes and resistor must have appropriate power ratings.


Figure 14. Output Transient Voltage Protection

\section*{BOARD LAYOUT AND GROUNDING}

The AD420 ground pin, designated GND, is the "high quality" ground reference point for the device. Any external loads on the REF OUT and VOUT pins of the AD420 should be returned to this reference point. Analog and digital ground currents should not share a common path. Each signal should have an appropriate analog or digital signal return routed close to it. Using this approach, signal loops enclose a small area, minimizing the inductive coupling of noise. Wide PC tracks, large gauge wire, and ground planes are highly recommended to provide low impedance signal paths.

\section*{POWER SUPPLIES AND DECOUPLING}

The AD420 supply pins, \(\mathrm{V}_{\mathrm{CC}}\) (Pin 23) and \(\mathrm{V}_{\mathrm{LL}}\) (Pin 2), should be decoupled to GND with \(0.1 \mu \mathrm{~F}\) capacitors to eliminate high frequency noise that may otherwise get coupled into the analog system. High frequency ceramic capacitors are recommended. The decoupling capacitors should be located in close proximity to the pins and the ground line to have maximum effect.

\section*{FEATURES}

\author{
Complete 8-Bit DAC \\ Voltage Output - 0 to 2.56 V \\ Internal Precision Band-Gap Reference \\ Single-Supply Operation: +5V ( \(\pm 10 \%\) ) \\ Full Microprocessor Interface \\ Fast: \(1 \mu \mathrm{~m}\) Voltage Settling to \(\mathbf{\pm 1 / 2 L S B}\) \\ Low Power: 75mW \\ No User Trims Required \\ Guaranteed Monotonic Over Temperature \\ All Errors Specified \(T_{\text {min }}\) to \(T_{\text {max }}\) \\ Small 16-Pin DIP or 20-Pin PLCC Package Low Cost
}

\section*{PRODUCT DESCRIPTION}

The AD557 DACPORT \({ }^{\text {TM }}\) is a complete voltage-output 8 -bit digital-to-analog converter, including output amplifier, full microprocessor interface and precision voltage reference on a single monolithic chip. No external components or trims are required to interface, with full accuracy, an 8-bit data bus to an analog system.

The low cost and versatility of the AD557 DACPORT are the result of continued development in monolithic bipolar technologies.

The complete microprocessor interface and control logic is implemented with integrated injection logic ( \(\mathrm{I}^{2} \mathrm{~L}\) ), an extremely dense and low-power logic structure that is process-compatible with linear bipolar fabrication. The internal precision voltage reference is the patented low-voltage band-gap circuit which permits full-accuracy performance on a single +5 V power supply Thin-film silicon-chromium resistors provide the stability required for guaranteed monotonic operation over the entire operating temperature range, while laser-wafer trimming of these thin-film resistors permits absolute calibration at the factory to within \(\pm 2.5 \mathrm{LSB}\); thus, no user-trims for gain or offset are required. A new circuit design provides voltage settling to \(\pm 1 / 2\) LSB for a full-scale step in 800 ns .
The AD557 is available in two package configurations. The AD557JN is packaged in a 16 -pin plastic, \(0.3^{\prime \prime}\)-wide DIP. For surface mount applications, the AD557JP is packaged in a 20-pin JEDEC standard PLCC. Both versions are specified over the operating temperature range of 0 to \(+70^{\circ} \mathrm{C}\).

\section*{FUNCTIONAL BLOCK DIAGRAM}


\section*{PRODUCT HIGHLIGHTS}
1. The 8 -bit \(\mathrm{I}^{2} \mathrm{~L}\) input register and fully microprocessorcompatible control logic allow the AD557 to be directly connected to 8 - or 16 -bit data buses and operated with standard control signals. The latch may be disabled for direct DAC interfacing.
2. The laser-trimmed on-chip SiCr thin-film resistors are calibrated for absolute accuracy and linearity at the factory. Therefore, no user trims are necessary for full rated accuracy over the operating temperature range.
3. The inclusion of a precision low-voltage band-gap reference eliminates the need to specify and apply a separate reference source.
4. The AD557 is designed and specified to operate from a single +4.5 V to +5.5 V power supply.
5. Low digital input currents, \(100 \mu \mathrm{~A}\) max, minimize bus loading. Input thresholds are TTL/low voltage CMOS compatible.
6. The single-chip, low power \(I^{2} \mathrm{~L}\) design of the AD557 is inherently more reliable than hybrid multichip or conventional single-chip bipolar designs.
\begin{tabular}{|c|c|c|c|c|}
\hline Model & Min & \[
\begin{gathered}
\text { AD557J } \\
\text { Typ }
\end{gathered}
\] & Max & Units \\
\hline RESOLUTION & & & 8 & Bits \\
\hline \[
\begin{aligned}
& \text { RELATIVE ACCURACY }{ }^{1} \\
& 0 \text { to }+70^{\circ} \mathrm{C}
\end{aligned}
\] & & \(\pm 1 / 2\) & 1 & LSB \\
\hline OUTPUT
Ranges
Current Source
Sink & +5 & \begin{tabular}{l}
\[
0 \text { to }+
\] \\
Internal Pull-Dow
\end{tabular} & round \({ }^{2}\) & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{~mA}
\end{aligned}
\] \\
\hline OUTPUT SETTLING TIME \({ }^{3}\) & & 0.8 & 1.5 & \(\mu \mathrm{S}\) \\
\hline ```
FULLSCALE ACCURACY4
    @25}\mp@subsup{}{}{\circ}\textrm{C
    T min to T Tmax
``` & & \[
\begin{aligned}
& \pm 1.5 \\
& \pm 2.5
\end{aligned}
\] & \[
\begin{aligned}
& \pm 2.5 \\
& \pm 4.0
\end{aligned}
\] & \[
\begin{aligned}
& \text { LSB } \\
& \text { LSB }
\end{aligned}
\] \\
\hline ZERO ERROR
\[
\begin{aligned}
& @ 25^{\circ} \mathrm{C} \\
& \mathrm{~T}_{\min } \text { to } \mathrm{T}_{\max }
\end{aligned}
\] & & & \[
\begin{aligned}
& \pm 1 \\
& \pm 3
\end{aligned}
\] & \[
\begin{aligned}
& \text { LSB } \\
& \text { LSB }
\end{aligned}
\] \\
\hline \[
\begin{aligned}
& \text { MONOTONICITY } \\
& \mathrm{T}_{\min } \text { to } \mathrm{T}_{\max }
\end{aligned}
\] & & Guarant & & \\
\hline \begin{tabular}{l}
DIGITALINPUTS \\
\(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) \\
Input Current \\
Data Inputs, Voltage \\
Bit On-Logic " 1 " \\
Bit On-Logic " 0 " \\
Control Inputs, Voltage \\
On-Logic " 1 " \\
On-Logic " 0 " \\
Input Capacitance
\end{tabular} & \[
\begin{aligned}
& 2.0 \\
& 0 \\
& 2.0 \\
& 0
\end{aligned}
\] & \[
4
\] & \[
\begin{aligned}
& \pm 100 \\
& 0.8 \\
& 0.8
\end{aligned}
\] & \begin{tabular}{l}
\(\mu . A\) \\
V \\
V \\
V \\
V \\
pF
\end{tabular} \\
\hline \begin{tabular}{l}
TIMING \\
\({ }^{\text {tw }}\) Strobe Pulse Width \\
\(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) \\
\(t_{D H}\) Data Hold Time \\
\(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) \\
\(t_{\text {DS }}\) Data Setup Time \\
\(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\)
\end{tabular} & \[
\begin{aligned}
& 225 \\
& \mathbf{3 0 0} \\
& 10 \\
& 10 \\
& 225 \\
& \mathbf{3 0 0}
\end{aligned}
\] & & & \begin{tabular}{l}
ns \\
ns ns ns ns ns
\end{tabular} \\
\hline \begin{tabular}{l}
POWER SUPPLY \\
Operating Voltage Range ( \(\mathrm{V}_{\mathrm{CC}}\) ) \\
2.56 Volt Range \\
Current ( \(\mathrm{I}_{\mathrm{CC}}\) ) \\
Rejection Ratio
\end{tabular} & +4.5 & 15 & \[
\begin{aligned}
& +5.5 \\
& 25 \\
& 0.03
\end{aligned}
\] & \begin{tabular}{l}
V \\
mA \\
\%/\%
\end{tabular} \\
\hline POWER DISSIPATION, \(\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}\) & & 75 & 125 & mW \\
\hline OPERATING TEMPERATURE RANGE & 0 & & +70 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

\section*{PIN CONFIGURATIONS}


\section*{NOTES}
\({ }^{1}\) Relative Accuracy is defined as the deviation of the code transition points from the ideal transfer point on a straight line from the offset to the full scale of the device. See "Measuring Offset Error" on AD558 data sheet.
\({ }^{2}\) Passive pull-down resistance is \(2 \mathrm{k} \Omega\).
\({ }^{3}\) Settling time is specified for a positive-going full-scale step to \(\pm 1 / 2\) LSB. Negative-going steps to zero
are slower, but can be improved with an external pull-down.
\({ }^{4}\) The full-scale output voltage is 2.55 V and is guaranteed with a +5 V supply.
\({ }^{5}\) A monotonic converter has a maximum differential linearity error of \(\pm 1\) LSB.
Specifications shown in boldface are tested on all production units at final electrical test.
Specifications subject to change without notice.

\section*{ABSOLUTE MAXIMUM RATINGS*}
\begin{tabular}{|c|c|}
\hline \multicolumn{2}{|l|}{\(\mathrm{V}_{\mathrm{CC}}\) to Ground . . . . . . . . . . . . . . . . . . 0 V to +18 V} \\
\hline \multicolumn{2}{|l|}{Digital Inputs (Pins 1-10) . . . . . . . . . . . . . 0 to +7.0V} \\
\hline Vout & Indefinite Short to Ground Momentary Short to \(\mathrm{V}_{\mathrm{CC}}\) \\
\hline Power Dissipation & Om \\
\hline Storage Temperature Range & \\
\hline N/P (Plastic) Packages & \(-25^{\circ} \mathrm{C}\) to \(+100^{\circ} \mathrm{C}\) \\
\hline ead Temperature (solder & \(300^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

Thermal Resistance
Junction to Ambient/Junction to Case N/P (Plastic) Packages
\(140 / 55^{\circ} \mathrm{C} / \mathrm{W}\)

\footnotetext{
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
}

DACPORT Low Cost, Complete

FEATURES
Complete 8-Bit DAC
Voltage Output - 2 Calibrated Ranges
Internal Precision Band-Gap Reference
Single-Supply Operation: +5 V to +15 V
Full Microprocessor Interface
Fast: \(1 \mu \mathrm{~s}\) Voltage Settling to \(\pm 1 / 2\) LSB
Low Power: 75mW
No User Trims
Guaranteed Monotonic Over Temperature
All Errors Specified \(\mathrm{T}_{\min }\) to \(\mathrm{T}_{\max }\)
Small 16-Pin DIP and 20-Pin PLCC Packages
Single Laser-Wafer-Trimmed Chip for Hybrids
Low Cost
MIL-STD883 Compliant Versions Available

\section*{PRODUCT DESCRIPTION}

The AD558 DACPORT \({ }^{T M}\) is a complete voltage-output 8-bit digital-to-analog converter, including output amplifier, full microprocessor interface and precision voltage reference on a single monolithic chip. No external components or trims are required to interface, with full accuracy, an 8 -bit data bus to an analog system.

The performance and versatility of the DACPORT is a result of several recently-developed monolithic bipolar technologies. The complete microprocessor interface and control logic is implemented with integrated injection logic ( \(\mathrm{I}^{2} \mathrm{~L}\) ), an extremely dense and low-power logic structure that is process-compatible with linear bipolar fabrication. The internal precision voltage reference is the patented low-voltage band-gap circuit which permits full-accuracy performance on a single +5 V to +15 V power supply. Thin-film silicon-chromium resistors provide the stability required for guaranteed monotonic operation over the entire operating temperature range (all grades), while recent advances in laser-wafer-trimming of these thinfilm resistors permit absolute calibration at the factory to within \(\pm 1\) LSB; thus no user-trims for gain or offset are required. A new circuit design provides voltage settling to \(\pm 1 / 2 \mathrm{LSB}\) for a full-scale step in 800 ns .

The AD558 is available in four performance grades. The AD558J and K are specified for use over the 0 to \(+70^{\circ} \mathrm{C}\) temperature range, while the AD558S and T grades are specified for \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) operation. The " J " and " K " grades are available either in 16 -pin plastic ( N ) or hermetic ceramic (D) DIPS. They are also available in 20-pin JEDEC standard PLCC packages. The " \(S\) " and " \(T\) " grades are available in the 16-pin hermetic ceramic DIP package.

\footnotetext{
\({ }^{*}\) Protected by U.S. Patent Nos. 3,887,863; 3,685,045; 4,323,795; Patents Pending.
DACPORT is a trademark of Analog Devices, Inc.
}

FUNCTIONAL BLOCK DIAGRAM


\section*{PRODUCT HIGHLIGHTS}
1. The 8 -bit \(\mathrm{I}^{2} \mathrm{~L}\) input register and fully microprocessorcompatible control logic allow the AD558 to be directly connected to 8 - or 16 -bit data buses and operated with standard control signals. The latch may be disabled for direct DAC interfacing.
2. The laser-trimmed on-chip SiCr thin-film resistors are calibrated for absolute accuracy and linearity at the factory. Therefore, no user trims are necessary for full rated accuracy over the operating temperature range.
3. The inclusion of a precision low-voltage band-gap reference eliminates the need to specify and apply a separate reference source.
4. The voltage-switching structure of the AD558 DAC section along with a high-speed output amplifier and laser-trimmed resistors give the user a choice of 0 V to +2.56 V or 0 V to +10 V output ranges, selectable by pin-strapping. Circuitry is internally compensated for minimum settling time on both ranges; typically settling to \(\pm 1 / 2\) LSB for a full-scale 2.55 volt step in 800 ns .
5. The AD558 is designed and specified to operate from a single +4.5 V to +16.5 V power supply.
6. Low digital input currents, \(100 \mu \mathrm{~A}\) max, minimize bus loading. Input thresholds are TTL/low voltage CMOS compatible over the entire operating \(V_{\mathbf{C C}}\) range.
7. All AD558 grades are available in chip form with guaranteed specifications from \(+25^{\circ} \mathrm{C}\) to \(\mathrm{T}_{\text {max }}\). MīiL-STD-883, Class B visual inspection is standard on Analog Devices bipolar chips. Contact the factory for additional chip information.
8. The AD558 is available in versions compliant with MIL-STD-883. Refer to Analog Devices Military Products Databook or current AD588/883B data sheet for detailed specifications.

SPECIFICATIONS
(@ \(T_{A}=+25^{\circ} C, V_{C C}=+5 V\) to \(+15 V\) unless otherwise specified)
AD558
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Model} & \multicolumn{3}{|c|}{AD558J} & \multicolumn{3}{|c|}{AD558K} & \multicolumn{3}{|c|}{AD558S \({ }^{1}\)} & \multicolumn{3}{|c|}{AD558T \({ }^{1}\)} & \multirow[b]{2}{*}{Units} \\
\hline & Min & Typ & Max & Min & Typ & Max & Min & & Max & Min & Typ & Max & \\
\hline RESOL.UTION & & & 8 & & & 8 & & & 8 & & & 8 & Bits \\
\hline \[
\begin{aligned}
& \text { RELATIVE ACCURACY }{ }^{2} \\
& 0 \text { to }+70^{\circ} \mathrm{C} \\
& -55^{\circ} \mathrm{C} \text { to }+125^{\circ} \mathrm{C} \\
& \hline
\end{aligned}
\] & & & \(\pm \mathbf{1 / 2}\) & & & \(\pm 1 / 4\) & & & \[
\begin{aligned}
& \pm 1 / 2 \\
& \pm 3 / 4
\end{aligned}
\] & & & \[
\begin{aligned}
& \pm 1 / 4 \\
& \pm 3 / 8
\end{aligned}
\] & \[
\begin{aligned}
& \text { LSB } \\
& \text { LSB }
\end{aligned}
\] \\
\hline \begin{tabular}{l}
OUTPUT \\
Ranges \({ }^{3}\) \\
Current Source Sink
\end{tabular} & +5 & \[
\begin{aligned}
& 0 \text { to }+2 \\
& 0 \text { to }+1 \\
& \text { Intern } \\
& \text { Pull-D }
\end{aligned}
\] & sive to Ground \({ }^{4}\) & +5 & \[
\begin{aligned}
& 0 \text { to }+2 \\
& 0 \text { to }+1 \\
& \text { Internal } \\
& \text { Pull-Do }
\end{aligned}
\] & sive o Ground & + 5 & \[
\begin{aligned}
& 0 \text { to }+2 \\
& 0 \text { to }+1 \\
& \text { Interna } \\
& \text { Pull-D }
\end{aligned}
\] & sive to Ground & \[
+5
\] & \[
\begin{aligned}
& 0 \text { to }+2 \\
& 0 \text { to }+1 \\
& \text { Internal } \\
& \text { Pull-Do }
\end{aligned}
\] & sive oo Ground & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{~V} \\
& \mathrm{~mA}
\end{aligned}
\] \\
\hline OUTPUT SETTLING TIME \({ }^{3}\) 0 to 2.56 Volt Range 0 to 10 Volt Range \({ }^{4}\) & & & \[
\begin{aligned}
& 1.5 \\
& 3.0
\end{aligned}
\] & & & \[
\begin{aligned}
& 1.5 \\
& 3.0 \\
& \hline
\end{aligned}
\] & & \[
\begin{aligned}
& 0.8 \\
& 2.0
\end{aligned}
\] & \[
\begin{aligned}
& 1.5 \\
& 3.0 \\
& \hline
\end{aligned}
\] & & \[
\begin{aligned}
& 0.8 \\
& 2.0
\end{aligned}
\] & \[
\begin{aligned}
& 1.5 \\
& 3.0 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \mu \mathrm{s} \\
& \mu \mathrm{~s}
\end{aligned}
\] \\
\hline \[
\begin{aligned}
& \text { FULL SCALE ACCURACY } \\
& \text { @ } 25^{\circ} \mathrm{C} \\
& \mathrm{~T}_{\min } \text { to } \mathrm{T}_{\max } \\
& \hline
\end{aligned}
\] & & & \[
\begin{aligned}
& \pm 1.5 \\
& \pm 2.5
\end{aligned}
\] & & & \[
\begin{aligned}
& \pm 0.5 \\
& \pm 1
\end{aligned}
\] & & & \[
\begin{aligned}
& \pm 1.5 \\
& \pm 2.5
\end{aligned}
\] & & & \[
\begin{aligned}
& \pm 0.5 \\
& \pm 1
\end{aligned}
\] & \[
\begin{aligned}
& \text { LSB } \\
& \text { LSB }
\end{aligned}
\] \\
\hline \[
\begin{aligned}
& \text { ZEROERROR } \\
& \text { @ } 25^{\circ} \mathrm{C} \\
& \mathrm{~T}_{\text {min }} \text { to } \mathrm{T}_{\text {max }} \\
& \hline
\end{aligned}
\] & & & \[
\begin{aligned}
& \pm 1 \\
& \pm 2
\end{aligned}
\] & & & \[
\begin{aligned}
& \pm 1 / 2 \\
& \pm 1 \\
& \hline
\end{aligned}
\] & & & \[
\begin{aligned}
& \pm 1 \\
& \pm 2
\end{aligned}
\] & & & \[
\begin{aligned}
& \pm 1 / 2 \\
& \pm 1 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \text { LSB } \\
& \text { LSB } \\
& \hline
\end{aligned}
\] \\
\hline MONOTONICITY \({ }^{7}\) \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & \multicolumn{3}{|c|}{Guaranteed} & \multicolumn{3}{|c|}{Guaranteed} & \multicolumn{3}{|c|}{Guaranteed} & \multicolumn{3}{|c|}{Guaranteed} & \\
\hline \begin{tabular}{l}
DIGITAL INPUTS \\
\(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) \\
Input Current \\
Data Inputs, Voltage Bit On-Logic " 1 " \\
BitOn-Logic " 0 " \\
Control Inputs, Voltage \\
On-Logic" 1 " \\
On-Logic "0" \\
Input Capacitance
\end{tabular} & \[
\begin{aligned}
& 2.0 \\
& 0 \\
& 2.0 \\
& 0
\end{aligned}
\] & 4 & \(\pm 100\)
0.8
0.8 & \[
\begin{aligned}
& 2.0 \\
& 0 \\
& 2.0 \\
& 0
\end{aligned}
\] & & \(\pm 100\)

0.8 & \[
\begin{aligned}
& 2.0 \\
& 0 \\
& 2.0 \\
& 0
\end{aligned}
\] & \[
4
\] & \(\pm 100\)

0.8 & \[
\begin{aligned}
& 2.0 \\
& 0 \\
& 2.0 \\
& 0
\end{aligned}
\] & & 100

0.8 & \begin{tabular}{l}
\(\mu \mathrm{A}\) \\
v \\
v \\
v \\
V \\
pF
\end{tabular} \\
\hline \begin{tabular}{l}
TIMING \\
\(t_{\text {w }}\) Strobe Pulse Width \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) \(t_{\text {DH }}\) Data Hold Time \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) \(t_{\text {DS }}\) Data Set-Up Time \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\)
\end{tabular} & \[
\begin{aligned}
& 200 \\
& 270 \\
& 10 \\
& 10 \\
& 200 \\
& 270
\end{aligned}
\] & & & \[
\begin{aligned}
& 200 \\
& 270 \\
& 10 \\
& 10 \\
& 200 \\
& 270
\end{aligned}
\] & & & \[
\begin{aligned}
& 200 \\
& 270 \\
& 10 \\
& 10 \\
& 200 \\
& 270 \\
& \hline
\end{aligned}
\] & & & \[
\begin{aligned}
& 200 \\
& 270 \\
& 10 \\
& 10 \\
& 200 \\
& 270
\end{aligned}
\] & & &  \\
\hline ```
POWER SUPPLY
    Operating Voltage Range(V}\mp@subsup{V}{CC}{\prime
        2.56 Volt Range
        10 Volt Range
        Current (ICC)
        Rejection Ratio
``` & \[
\begin{aligned}
& +4.5 \\
& +11.4
\end{aligned}
\] & 15 & \[
\begin{aligned}
& +16.5 \\
& +16.5 \\
& 25 \\
& 0.03
\end{aligned}
\] & \[
\begin{aligned}
& +4.5 \\
& +11.4
\end{aligned}
\] & 15 & \[
\begin{aligned}
& +16.5 \\
& +16.5 \\
& 25 \\
& 0.03
\end{aligned}
\] & +4.5
+11.4 & \[
15
\] & \[
\begin{aligned}
& +16.5 \\
& +16.5 \\
& 25 \\
& 0.03 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& +4.5 \\
& +11.4
\end{aligned}
\] & 15 & \[
\begin{aligned}
& +16.5 \\
& +16.5 \\
& 25 \\
& 0.03 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
v \\
v \\
mA \\
\%/\%
\end{tabular} \\
\hline \[
\begin{aligned}
\text { POWER DISSIPATION, } \mathrm{v}_{\mathrm{cc}}=5 \mathrm{~V} \\
\mathrm{v}_{\mathrm{cc}}=15 \mathrm{~V} \\
\hline
\end{aligned}
\] & & \[
\begin{aligned}
& 75 \\
& 225 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 125 \\
& 375
\end{aligned}
\] & & \[
\begin{aligned}
& 75 \\
& 225 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 125 \\
& 375 \\
& \hline
\end{aligned}
\] & & \[
\begin{aligned}
& 75 \\
& 225 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 125 \\
& 375 \\
& \hline
\end{aligned}
\] & & \[
\begin{aligned}
& 75 \\
& 225 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 125 \\
& 375 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{mW} \\
& \mathrm{~mW} \\
& \hline
\end{aligned}
\] \\
\hline OPERATING TEMPERATURE RANGE & 0 & & +70 & 0 & & +70 & -55 & & +125 & -55 & & +125 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) The AD558 S \& T grades are available processed and screened to MIL-STD-883 Class B. Consult Analog Devices' Military Databook for details.
\({ }^{2}\) Relative Accuracy is defined as the deviation of the code transition points from the ideal transfer point on a straight line from the offset to the full scale of the device. See "Measuring
Offset Error".
\({ }^{3}\) Operation of the 0 to 10 volt output range requires a minimum supply voltage of +11.4 volts.
\({ }^{4}\) Passive pull-down resistance is \(2 \mathrm{k} \Omega\) for 2.56 volt range, \(10 \mathrm{k} \Omega\) for 10 volt range.
\({ }^{5}\) Sertling time is specified for a positive-going full-scale step to \(\pm 1 / 2 \mathrm{LSB}\). Negative-going steps to zero are slower, but can be improved with an external pull-down.
\({ }^{6}\) The full range output voltage for the 2.56 range is 2.55 V and is guaranteed with a +5 V supply, for the 10 V range, it is 9.960 V guaranteed with a +15 V supply.
\({ }^{7}\) A monotonic converter has a maximum differential linearity error of \(\pm 1\) LSB.
Specifications shown in boldface are tested on all production units at final electrical test.
Specifications subject to change without notice.

\section*{AD558}

ABSOLUTE MAXIMUM RATINGS*
VCC to Ground . . . . . . . . . . . . . . . . . . \(0 V\) to +18 V
Digital Inputs (Pins 1-10) . . . . . . . . . . . . 0V to +7.0 V
Vout . . . . . . . . . . . . . . . Indefinite Short to Ground Momentary Short to \(\mathrm{V}_{\mathrm{CC}}\)
Power Dissipation . . . . . . . . . . . . . . . . . . . 450mW
Storage Temperature Range
N/P (Plastic) Packages . . . . . . . . . \(-25^{\circ} \mathrm{C}\) to \(+100^{\circ} \mathrm{C}\)
D (Ceramic) Package . . . . . . . . . . \(-55^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Lead Temperature (soldering, 10 sec ) . . . . . . . . . . \(300^{\circ} \mathrm{C}\)
Thermal Resistance
Junction to Ambient/Junction to Case
D (Ceramic) Package
\(100 / 30^{\circ} \mathrm{C} / \mathrm{W}\)
N/P (Plastic) Packages \(140 / 55^{\circ} \mathrm{C} / \mathrm{W}\)
*Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

\section*{AD558 METALIZATION PHOTOGRAPH}

Dimensions shown in inches and (mm).


ORDERING GUIDE
\begin{tabular}{|c|c|c|c|c|}
\hline Model \({ }^{1}\) & Temperature & \begin{tabular}{l}
Relative Accuracy Error Max \\
\(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\)
\end{tabular} & Full Scale Error, Max \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & Package Option \({ }^{2}\) \\
\hline AD558JN & 0 to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 / 2\) LSB & \(\pm 2.5 \mathrm{LSB}\) & Plastic (N-16) \\
\hline AD558JP & 0 to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 / 2\) LSB & \(\pm 2.5\) LSB & PLCC(P-20A) \\
\hline AD558JD & 0 to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 / 2\) LSB & \(\pm 2.5 \mathrm{LSB}\) & TO-116(D-16) \\
\hline AD558KN & 0 to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 / 4 \mathrm{LSB}\) & \(\pm 1 \mathrm{LSB}\) & Plastic (N-16) \\
\hline AD558KP & 0 to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 / 4 \mathrm{LSB}\) & \(\pm 1\) LSB & PLCC(P-20A) \\
\hline AD558KD & 0 to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 / 4 \mathrm{LSB}\) & \(\pm 1 \mathrm{LSB}\) & TO-116(D-16) \\
\hline AD558SD & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 3 / 4 \mathrm{LSB}\) & \(\pm 2.5 \mathrm{LSB}\) & TO-116(D-16) \\
\hline AD558TD & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 3 / 8 \mathrm{LSB}\) & \(\pm 1 \mathrm{LSB}\) & TO-116(D-16) \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) For details on grade and package offerings screened in accordance with MIL-STD-883, refer to Analog Devices' Military Products Databook or current AD558/883B data sheet.
\({ }^{2}\) D = Ceramic DIP; N = Plastic DIP; P = Plastic Leaded Chip Carrier. For outline information see Package Information section.


Figure 1a. AD558 Pin Configuration (DIP)


Figure 1b. AD558 Pin Configuration (PLCC)

ANALOG
High Speed 12-Bit Monolithic D/A Converters

\section*{FEATURES}

Single Chip Construction
Very High-Speed Settling to 1/2LSB
AD565A: 250ns max
AD566A: 350ns max
Full-Scale Switching Time: 30ns
Guaranteed for Operation with \(\pm 12 \mathrm{~V}\) Supplies: AD565A with -12V Supply: AD566A
Linearity Guaranteed Over Temperature: 1/2 LSB max (K, T Grades)
Monotonicity Guaranteed Over Temperature
Low Power: \(A D 566 A=180 \mathrm{~mW}\) max;
AD565A \(=225 \mathrm{~mW}\) max
Use with On-Board High-Stability Reference (AD565A) or with External Reference (AD566A)
Low Cost
MIL-STD-883-Compliant Versions Available

\section*{PRODUCT DESCRIPTION}

The AD565A and AD566A are fast 12-bit digital-to-analog converters which incorporate the latest advances in analog circuit design to achieve high speeds at low cost.

The AD565A and AD566A use 12 precision, high-speed bipolar current-steering switches, control amplifier and a laser-trimmed thin-film resistor network to produce a very fast, high accuracy analog output current. The AD565A also incluess a buried zener reference that features low-noise, long-term stability and temperature drift characteristics comparable to the best discrete reference diodes.
The combination of performance and flexibility in the AD565A and AD566A has resulted from major innovations in circuit design, an important new high-speed bipolar process, and continuing advances in laser-wafer-trimming techniques (LWT). The AD565A and AD566A have a \(10-90 \%\) full-scale transition time less than 35 ns and settle to within \(\pm 1 / 2\) LSB in 250 ns max ( 350 ns for AD566A). Both are laser-trimmed at the wafer level to \(\pm 1 / 8 \mathrm{LSB}\) typical linearity and are specified to \(\pm 1 / 4 \mathrm{LSB}\) max error ( K and T grades) at \(+25^{\circ} \mathrm{C}\). High speed and accuracy make the AD565A and AD566A the ideal choice for high-speed display drivers as well as fast analog-to-digital converters.
The laser trimming process which provides the excellent linearity is also used to trim both the absolute value and the tempert ture coefficient of the reference of the AD565A resulting in a typical full-scale gain TC of \(10 \mathrm{ppm} /{ }^{\circ} \mathrm{C}\). When tighter TC performance is required or when a system reference is available, the AD566A may be used with an external reference.
\({ }^{*}\) Covered by Patent Nos.s 3,803,590; RE 28,633; 4,213,806; 4,136,349; 4,020,486; 3,747,088.

This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.


AD565A and AD566A are available in four performance grades. The \(J\) and \(K\) are specified for use over the 0 to \(+70^{\circ} \mathrm{C}\) temperature range while the S and T grades are specified for the \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) range. The D grades are all packaged in a 24 -pin, hermetically sealed, ceramic, dual-in-line package. The JR grade is packaged in a 28 -pin plastic SOIC.

\section*{PRODUCT HIGHLIGHTS}
1. The wide output compliance range of the AD565A and AD566A are ideally suited for fast, low noise, accurate voltage output configurations without an output amplifier.
2. The devices incorporate a newly developed, fully differential, nonsaturating precision current switching cell structure which combines the dc accuracy and stability first developed in the AD562/3 with very fast switching times and an opti-mally-damped settling characteristic.
3. The devices also contain SiCr thin film application resistors which can be used with an external op amp to provide a precision voltage output or as input resistors for a successive approximation A/D converter. The resistors are matched to the internal ladder network to guarantee a low gain temperature coefficient and are laser-trimmed for minimum full-scale and bipolar offset errors.
4. The AD565A and AD566A are available in versions compliant with MIL-STD-883. Refer to the Analog Devices Military Products Databook or current /883B data sheet for detailed specifications.

AD565A-SPECIFICATIONS
\(\left(T_{A}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=+15 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=+15 \mathrm{~V}\right.\), unless otherwise specified.)




MULTIPLYING MODE PERFORMANCE (All Models)
Quadrants
Reference Volta

\section*{Accuracy
Reference Feedthrough (unipolar mode,} all bits OFF, and 1 to \(+10 \mathrm{~V}[\mathrm{p}-\mathrm{p}]\), sinewave frequency for \(\mathbf{1 / 2 L S B}\) ( \(p-p\) ] feedthrough)
Output Slew Rate 10\%-90\% 90\%-10\%
Output Settling Time (all bits on and \(20-10 V\) step change in reference voltage)

Two (2): Bipolar Operation at Digital Input Only
+1 V to +10 V , Unipolar
\(\mathbf{1 0}\) Bits ( \(\mathbf{\pm 0 . 0 5 \%}\) of Reduced F.S.) for 1 V de Reference Voltage

40kHz typ
\(5 \mathrm{~mA} / \mu_{\mathrm{s}}\)
\(1 \mathrm{~mA} / \mu \mathrm{s}\)
1.5 \(\mu\) s to 0.01\% F.S.

CONTROL AMPLIFIER

\section*{300kHz}
1.8 MHz

\section*{NOTES}
\({ }^{1}\) The digital input levels are guaranteed but not tested over the uemperature range.
\({ }^{2}\) The power supply gain sensitivity is terted in reference to a \(V_{E E}\) of -15 V dc .
Specifications subject to change without notice.


\section*{AD565A/AD566A}

\section*{ABSOLUTE MAXIMUM RATINGS}

VCC to Power Ground . . . . . . . . . . . . . . . OV to +18 V
\(\mathrm{V}_{\mathrm{EE}}\) to Power Ground (AD565A) . . . . . . . . . \(0 V\) to -18 V
Voltage on DAC Output (Pin 9) . . . . . . . . \(-3 V\) to +12 V
Digital Inputs (Pins 13 to 24) to
Power Ground . . . . . . . . . . . . . . -1.0 V to +7.0 V
Ref in to Reference Ground . . . . . . . . . . . . . . . \(\pm 12 \mathrm{~V}\)
Bipolar Offset to Reference Ground . . . . . . . . . . . \(\pm 12 \mathrm{~V}\)
10V Span R to Reference Ground . . . . . . . . . . . . \(\pm 12 \mathrm{~V}\)
20V Span R to Reference Ground . . . . . . . . . . . . \(\pm 24 \mathrm{~V}\)
Ref out (AD565A) . . . . . Indefinite Short to Power Ground Momentary Short to \(V_{\text {CC }}\)
Power Dissipation \(\qquad\)

AD565A ORDERING GUIDE
\begin{tabular}{l|l|l|l|l}
\hline & \begin{tabular}{l} 
Max Gain T.C. \\
(ppm of F.S. \(/^{\circ} \mathrm{C}\) )
\end{tabular} & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Linearity \\
Error Max \\
\(@+25^{\circ} \mathrm{C}\)
\end{tabular} & \begin{tabular}{l} 
Package \\
Option \({ }^{2}\)
\end{tabular} \\
\hline AD565AJD & 50 & 0 to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & Ceramic(D-24) \\
AD565AJR & 50 & 0 to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & SOIC(R-28) \\
AD565AKD & 20 & 0 to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 / 4 \mathrm{LSB}\) & Ceramic(D-24) \\
AD565ASD & 30 & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & Ceramic(D-24) \\
AD565ATD & 15 & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 / 4 \mathrm{LSB}\) & Ceramic(D-24) \\
\hline
\end{tabular}

NOTES
\({ }^{1}\) For details on grade and package offerings screened in accordance with MIL-STD-883, refer to the Analog Devices Military Products Databook or current/883B data sheet.
\({ }^{2} \mathrm{D}=\) Ceramic DIP, \(\mathrm{R}=\) SOIC. For outline information see Package Information section.

AD566A ORDERING GUIDE
\begin{tabular}{l|l|l|l|l}
\hline & \begin{tabular}{l} 
Max Gain T.C. \\
(ppm or F.S. \({ }^{\circ} \mathrm{C}\) )
\end{tabular} & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Linearity \\
Error Max \\
\(@+25^{\circ} \mathrm{C}\)
\end{tabular} & \begin{tabular}{l} 
Package \\
Option \(^{2}\)
\end{tabular} \\
\hline AD566AJD & 10 & 0 to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \begin{tabular}{l} 
Ceramic(D-24) \\
AD566AKD
\end{tabular} \\
ADS66ASD & 10 & 0 to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 / 4 \mathrm{LSB}\) & \begin{tabular}{l} 
Ceramic (D-24) \\
AD566ATD
\end{tabular} \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) For details on grade and package offerings screened in accordance with MIL-STD-883, refer to the Analog Devices Military Products Databook or current /883B data sheet.
\({ }^{2} \mathrm{D}=\) Ceramic DIP. For outline information see Package Information section.

PIN DESIGNATIONS


28-PIN SOIC


AD568

FEATURES
Ultrahigh Speed: Current Settling to 1LSB in 35ns High Stability Buried Zener Reference on Chip Monotonicity Guaranteed Over Temperature 10.24 mA Full-Scale Output Suitable for Video Applications
Integral and Differential Linearity Guaranteed Over Temperature
\(0.3^{\prime \prime}\) "Skinny DIP" Packaging
Variable Threshold Allows TTL and CMOS Interface
MIL-STD-883 Compliant Versions Available

FUNCTIONAL BLOCK DIAGRAM


\section*{PRODUCT DESCRIPTION}

The AD568 is an ultrahigh-speed, 12-bit digital-to-analog converter (DAC) settling to \(0.025 \%\) in \(35 n\). The monolithic device is fabricated using Analog Devices' Complementary Bipolar (CB) Process. This is a proprietary process featuring high-speed NPN and PNP devices on the same chip without the use of dielectric isolation or multichip hybrid techniques. The high speed of the AD568 is maintained by keeping impedance levels low enough to minimize the effects of parasitic circuit capacitances.

The DAC consists of 16 current sources configured to deliver a 10.24 mA full-scale current. Multiple matched current sources and thin-film ladder techniques are combined to produce bit weighting. The DAC's output is a 10.24 mA full scale (FS) for current output applications or a 1.024 V FS unbuffered voltage output. Additionally, a 10.24 V FS buffered output may be generated using an onboard \(1 \mathrm{k} \Omega\) span resistor with an external op amp. Bipolar ranges are accomplished by pin strapping.
Laser wafer trimming insures full 12-bit linearity. All grades of the AD568 are guaranteed monotonic over their full operating temperature range. Furthermore, the output resistance of the DAC is trimmed to \(100 \Omega \pm 1.0 \%\). The gain temperature coefficient of the voltage output is \(30 \mathrm{ppm} /{ }^{\circ} \mathrm{C} \max (\mathrm{K})\).
The AD568 is available in three performance grades. The AD568JQ and KQ are available in 24-pin cerdip ( \(0.3^{\prime \prime}\) ) packages and are specified for operation from 0 to \(+70^{\circ} \mathrm{C}\). The AD568SQ features operation from \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) and is also packaged in the hermetic \(0.3^{\prime \prime}\) cerdip.

\section*{PRODUCT HIGHLIGHTS}
1. The ultrafast settling time of the AD568 allows leading edge performance in waveform generation, graphics display and high-speed A/D conversion applications.
2. Pin strapping provides a variety of voltage and current output ranges for application versatility. Tight control of the absolute output current reduces trim requirements in externally-scaled applications.
3. Matched on-chip resistors can be used for precision scaling in high-speed \(\mathrm{A} / \mathrm{D}\) conversion circuits.
4. The digital inputs are compatible with TTL and +5 V CMOS logic families.
5. Skinny DIP ( \(0.3^{\prime \prime}\) ) packaging minimizes board space requirements and eases layout considerations.
6. The AD568 is available in versions compliant with MIL-STD883. Refer to the Analog Devices Military Products Databook or current AD568/883B data sheet for detailed specifications.

\footnotetext{
This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.
}


\section*{NOTES}
*Same as AD568J.
\({ }^{1}\) Measured in Iocr mode.
\({ }^{2}\) Measured in \(\mathrm{V}_{\text {OUT }}\) mode, unless otherwise specified. See text for further information.
\({ }^{3}\) Total Resistance. Refer to Figure 3.
\({ }^{4}\) At the major carry, driven by HCMOS logic. See text for further explanation.
\({ }^{5}\) Measured in \(\mathrm{V}_{\text {out }}\) mode.
Specifications shown in boldface are tested on all production units at final electrical test. Specifications subject to change without notice.


Figure 1. Functional Block Diagram

PIN CONFIGURATION


\section*{ABSOLUTE MAXIMUM RATINGS*}
\begin{tabular}{|c|c|}
\hline \(\mathrm{V}_{\mathrm{CC}}\) to REFCOM & 0 V to +18 V \\
\hline \(\mathrm{V}_{\text {EE }}\) to REFCOM & 0 V to -18 V \\
\hline REFCOM to LCOM & +100 mV to -10 V \\
\hline ACOM to LCOM & \(\pm 100 \mathrm{mV}\) \\
\hline THCOM to LCOM & \(\pm 500 \mathrm{mV}\) \\
\hline SPANs to LCOM & \(\pm 12 \mathrm{~V}\) \\
\hline \(\mathrm{I}_{\text {BPO }}\) to LCOM & . \(\pm 5 \mathrm{~V}\) \\
\hline I Out to LCOM & -5 V to \(\mathrm{V}_{\text {TH }}\) \\
\hline Digital Inputs to THCOM & -500 mV to +7.0 V \\
\hline Voltage Across Span Resistor & 12 V \\
\hline \(\mathrm{V}_{\text {TH }}\) to THCOM & -0.7V to +1.4 V \\
\hline & 5 m \\
\hline
\end{tabular}
Power Dissipation . . . . . . . . . . . . . . . . . . . 1000 mW
Storage Temperature Range
Q (Cerdip) Package . . . . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Junction Temperature . . . . . . . . . . . . . . . . \(175^{\circ} \mathrm{C}\)
Thermal Resistance
\(\theta_{\mathrm{ja}}\). . . . . . . . . . . . . . . . . . . . . . . . \(75^{\circ} \mathrm{C} / \mathrm{W}\)
\(\theta_{\mathrm{jc}} . . . . . . . . . . . . . . . . . . . . . . . . .25^{\circ} \mathrm{C} / \mathrm{W}\)
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ORDERING GUIDE
\begin{tabular}{|c|c|c|c|c|}
\hline Model \({ }^{1}\) & Package Option \({ }^{2}\) & Temperature Range \({ }^{\circ} \mathrm{C}\) & \begin{tabular}{l}
Linearity Error Max. \\
@ \(25^{\circ} \mathrm{C}\)
\end{tabular} & Voltage Gain T.C. Max ppm/ \({ }^{\circ} \mathrm{C}\) \\
\hline AD568JQ & 24-Lead Cerdip (Q-24) & 0 to +70 & \(\pm 1 / 2\) & \(\pm 50\) \\
\hline AD568KQ & 24-Lead Cerdip (Q-24) & 0 to +70 & \(\pm 1 / 4\) & \(\pm 30\) \\
\hline AD568SQ & 24-Lead Cerdip (Q-24) & -55 to +125 & \(\pm 1 / 2\) & \(\pm 50\) \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) For details on grade and package offerings screened in accordance with MIL-STD-883, refer to the Analog Devices Military Products Databook or current AD568/883B data sheet.
\({ }^{2} \mathrm{Q}=\) Cerdip. For outline information see Package Information section.

\section*{Definitions}

LINEARITY ERROR (also called INTEGRAL NONLINEARITY OR INL): Analog Devices defines linearity error as the maximum deviation of the actual analog output from the ideal output (a straight line drawn from 0 to FS) for any bit combination expressed in multiples of 1LSB. The AD568 is laser trimmed to \(1 / 4 \mathrm{LSB}\) ( \(0.006 \%\) of FS) maximum linearity error at \(+25^{\circ} \mathrm{C}\) for the K version and \(1 / 2 \mathrm{LSB}\) for the J and S versions.
DIFFERENTIAL LINEARITY ERROR (also called DIFFERENTIAL NONLINEARITY or DNL): DNL is the measure of the variation in analog value, normalized to full scale, associated with a 1LSB change in digital input code. Monotonic behavior requires that the differential linearity error not exceed lLSB in the negative direction.

MONOTONICITY: A DAC is said to be monotonic if the output either increases or remains constant as the digital input increases.

UNIPOLAR OFFSET ERROR: The deviation of the analog output from the ideal ( 0 V or 0 mA ) when the inputs are set to all 0 s is called unipolar offset error.

BIPOLAR OFFSET ERROR: The deviation of the analog output from the ideal (negative half-scale) when the inputs are set to all 0 s is called bipolar offset error.
BIPOLAR ZERO ERROR: The deviation of the analog output from the ideal half-scale output of 0 V (or 0 mA ) for bipolar mode when only the MSB is on ( \(100 \ldots . .00\) ) is called bipolar zero error.
GAIN ERROR: The difference between the ideal and actual output span of FS - 1LSB, expressed in \% of FS, or LSB, when all bits are on.
GLITCH IMPULSE: Asymmetrical switching times in a DAC give rise to undesired output transients which are quantified by their glitch impulse. It is specified as the net area of the glitch in nV-sec or pA-sec.

\section*{FEATURES}

Guaranteed 16-Bit Monotonicity
Monolithic BiMOS II Construction \(\pm \mathbf{0 . 0 1 \%}\) Typical Nonlinearity 8- and 16-Bit Bus Compatibility
\(3 \mu\) s Settling to 16-Bits
Low Drift
Low Power
Low Noise

\section*{APPLICATIONS}

Robotics
Closed-Loop Positioning
High-Resolution ADCs
Microprocessor-Based Process Control
MIL-STD-883 Compliant Versions Available

\section*{PRODUCT DESCRIPTION}

The AD569 is a monolithic 16-bit digital-to-analog converter (DAC) manufactured in Analog Devices' BiMOS II process. BiMOS II allows the fabrication of low power CMOS logic functions on the same chip as high precision bipolar linear circuitry. The AD569 chip includes two resistor strings, selector switches, decoding logic, buffer amplifiers, and double-buffered input latches.

The AD569's voltage-segmented architecture insures 16-bit monotonicity over time and temperature. Integral nonlinearity is maintained at \(\pm 0.01 \%\), while differential nonlinearity is \(\pm 0.0004 \%\). The on-chip, high-speed buffer amplifiers provide a voltage output settling time of \(3 \mu\) s to within \(\pm 0.001 \%\) for a full-scale step.
The reference input voltage which determines the output range can be either unipolar or bipolar. Nominal reference range is \(\pm 5 \mathrm{~V}\) and separate reference force and sense connections are provided for high accuracy applications. The AD569 can operate with an ac reference in multiplying applications.

Data may be loaded into the AD569's input latches from 8- and 16-bit buses. The double-buffered structure simplifies 8 -bit bus interfacing and allows multiple DACs to be loaded asynchronously and updated simultaneously. Four TTL/LSTTL/5V CMOScompatible signals control the latches: \(\overline{\mathrm{CS}}, \overline{\mathrm{LBE}}, \overline{\mathrm{HBE}}\), and LDAC.

The AD569 is available in five grades: J and K versions are specified from 0 to \(+70^{\circ} \mathrm{C}\) and are packaged in a 28 -pin plastic DIP and 28 -pin PLCC package; \(\mathbf{A D}\) and BD versions aré specified from \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) and are packaged in a 28 -pin ceramic DIP. The SD version, also in a 28 -pin ceramic DIP, is specified from \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\).

FUNCTIONAL BLOCK DIAGRAM


\section*{PRODUCT HIGHLIGHTS}
1. Monotonicity to 16 bits is insured by the AD569's voltagesegmented architecture.
2. The output range is ratiometric to an external reference or ac signal. Gain error and gain drift of the AD569 are negligible.
3. The AD569's versatile data input structure allows loading from 8 - and 16 -bit buses.
4. The on-chip output buffer amplifier can supply \(\pm 5 \mathrm{~V}\) into a \(1 \mathrm{k} \Omega\) load, and can drive capacitive loads of up to 1000 pF .
5. Kelvin connections to the reference inputs preserve the gain and offset accuracy of the transfer function in the presence of wiring resistances and ground currents.
6. The AD569 is available in versions compliant with MIL-STD883. Refer to the Analog Devices Military Products Databook or current AD569/883B data sheet for detailed specifications.

SpEGFGGT]DNG ( \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C},+\mathrm{V}_{\mathrm{S}}=+12 \mathrm{~V},-\mathrm{V}_{\mathrm{S}}=-12 \mathrm{~V},+\mathrm{V}_{\mathrm{REF}}=+5 \mathrm{~V},-\mathrm{V}_{\mathrm{REF}}=-5 \mathrm{~V}\), unless
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{\begin{tabular}{l}
Model \\
Parameter
\end{tabular}} & \multicolumn{3}{|c|}{AD569JN/JP/AD} & \multicolumn{3}{|c|}{AD569KN/KP/BD} & \multicolumn{3}{|c|}{AD569SD} & \multirow[b]{2}{*}{Units} \\
\hline & Min & Typ & Max & Min & Typ & Max & Min & Typ & Max & \\
\hline RESOLUTION & & & 16 & & & 16 & & & 16 & Bits \\
\hline LOGICINPUTS & & & & & & & & & & \\
\hline \(\mathrm{V}_{\text {IH }}\) (Logic " 1 ") & 2.0 & & 5.5 & 2.0 & & 5.5 & 2.0 & & 5.5 & Volts \\
\hline \(\mathrm{V}_{\text {IL }}\) (Logic "0") & 0 & & 0.8 & 0 & & 0.8 & 0 & & 0.8 & Volts \\
\hline \(\mathrm{I}_{\mathrm{IH}}\left(\mathrm{V}_{\mathrm{IH}}=5.5 \mathrm{~V}\right)\) & & & 10 & & & 10 & & & 10 & \(\mu \mathrm{A}\) \\
\hline \(\mathrm{I}_{\mathrm{IL}}\left(\mathrm{V}_{\mathrm{IL}}=0 \mathrm{~V}\right)\) & & & 10 & & & 10 & & & 10 & \(\mu \mathrm{A}\) \\
\hline \multicolumn{11}{|l|}{\multirow[t]{2}{*}{TRANSFER FUNCTION CHARACTERISTICS}} \\
\hline & & & & & & & & & & \\
\hline Integral Nonlinearity & & \(\pm 0.02\) & \(\pm 0.04\) & & \(\pm 0.01\) & \(\pm 0.024\) & & & \(\pm 0.04\) & \% FSR \({ }^{1}\) \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & & \(\pm 0.02\) & \(\pm 0.04\) & & \(\pm 0.020\) & \(\pm 0.024\) & & & \(\pm 0.04\) & \% FSR \\
\hline Differential Nonlinearity & & \(\pm 1 / 2\) & \(\pm 1\) & & \(\pm 1 / 4\) & \(\pm 1 / 2\) & & & \(\pm 1\) & LSB \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & & \(\pm 1 / 2\) & \(\pm 1\) & & \(\pm 1 / 2\) & \(\pm 1\) & & & \(\pm 1\) & LSB \\
\hline Unipolar Offset \({ }^{2}\) & & & \(\pm 500\) & & & \(\pm 350\) & & & \(\pm 500\) & \(\mu \mathrm{V}\) \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & & & \(\pm 750\) & & & \(\pm 450\) & & & \(\pm 750\) & \(\mu \mathrm{V}\) \\
\hline Bipolar Offset \({ }^{2}\) & & & \(\pm 500\) & & & \(\pm 350\) & & & \(\pm 500\) & \(\mu \mathrm{V}\) \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & & & \(\pm 750\) & & & \(\pm 450\) & & & \(\pm 750\) & \(\mu \mathrm{V}\) \\
\hline Full Scale Error \({ }^{2}\) & & & \(\pm 350\) & & & \(\pm 350\) & & & \(\pm 350\) & \(\mu \mathrm{V}\) \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & & & \(\pm 750\) & & & \(\pm 750\) & & & \(\pm 750\) & \(\mu \mathrm{V}\) \\
\hline Bipolar Zero \({ }^{2}\) & & & \(\pm 0.04\) & & & \(\pm 0.024\) & & & \(\pm 0.04\) & \%FSR \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & & & \(\pm 0.04\) & & & \(\pm 0.024\) & & & \(\pm 0.04\) & \%FSR \\
\hline \multicolumn{11}{|l|}{REFERENCEINPUT} \\
\hline \(+\mathrm{V}_{\text {REF }}\) Range \({ }^{3}\) & -5 & & +5 & -5 & & +5 & -5 & & +5 & Volts \\
\hline - \(\mathrm{V}_{\text {REF }}\) Range \({ }^{3}\) & -5 & & +5 & -5 & & +5 & -5 & & +5 & Volts \\
\hline Resistance & 15 & 20 & 25 & 15 & 20 & 25 & 15 & 20 & 25 & \(\mathrm{k} \Omega^{4}\) \\
\hline \multicolumn{11}{|l|}{OUTPUTCHARACTERISTICS} \\
\hline Voltage & -5 & & +5 & -5 & & +5 & -5 & & +5 & Volts \\
\hline Capacitive Load & & & 1000 & & & 1000 & & & 1000 & pF \\
\hline Resistive Load & 1 & & & 1 & & & 1 & & & k \(\boldsymbol{\Omega}\) \\
\hline Short Circuit Current & & 10 & & & 10 & & & 10 & & mA \\
\hline \multicolumn{11}{|l|}{POWER SUPPLIES} \\
\hline \multicolumn{11}{|l|}{Voltage} \\
\hline \(+\mathrm{V}_{\text {S }}\) & +10.8 & +12 & +13.2 & +10.8 & +12 & +13.2 & +10.8 & +12 & +13.2 & Volts \\
\hline \(-V_{s}\) & -10.8 & -12 & -13.2 & -10.8 & -12 & -13.2 & -10.8 & -12 & -13.2 & Volts \\
\hline \multicolumn{11}{|l|}{Current} \\
\hline \(+\mathrm{I}_{5}\) & & +9 & +13 & & +9 & +13 & & +9 & +13 & mA \\
\hline - Is & & -9 & -13 & & -9 & -13 & & -9 & -13 & mA \\
\hline \multicolumn{11}{|l|}{Power Supply Sensitivity \({ }^{\text {s }}\)} \\
\hline \(+10.8 \mathrm{~V} \leq+\mathrm{V}_{\mathrm{S}} \leq+13.2 \mathrm{~V}\) & & \(\pm 0.5\) & \(\pm 2\) & & \(\pm 0.5\) & \(\pm 2\) & & \(\pm 0.5\) & \(\pm 2\) & ppm/\% \\
\hline \(-10.8 \mathrm{~V} \geq-\mathrm{V}_{\mathrm{S}} \geq-13.2 \mathrm{~V}\) & & \(\pm 1\) & \(\pm 3\) & & \(\pm 1\) & \(\pm 3\) & & \(\pm 1\) & \(\pm 3\) & ppm/\% \\
\hline \multicolumn{11}{|l|}{TEMPERATURERANGE} \\
\hline Specified & & & & & & & & & & \\
\hline JN, KN, JP, KP & 0 & & + 70 & 0 & & +70 & & & & \({ }^{\circ} \mathrm{C}\) \\
\hline AD, BD & -25 & & +85 & -25 & & +85 & & & & \({ }^{\circ} \mathrm{C}\) \\
\hline SD & & & & & & & -55 & & +125 & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage & & & & & & & & & & \\
\hline JN, KN, JP, KP & -65 & & \(+150\) & -65 & & + 150 & & & & \({ }^{\circ} \mathrm{C}\) \\
\hline AD, BD, SD & -65 & & \(+150\) & -65 & & +150 & -65 & & +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

NOTES
\({ }^{1}\) FSR stands for Full-Scale Range, and is 10 V for a -5 to +5 V span.
\({ }^{2}\) Refer to Definitions section.
\({ }^{3}\) For operation with supplies other than \(\pm 12 \mathrm{~V}\), refer to the Power Supply and Reference Voltage Range Section.
\({ }^{4}\) Measured between \(+V_{\text {REF }}\) Force and \(-V_{\text {REF }}\) Force.
\({ }^{5}\) Sensitivity of Full-Scale Error due to changes in \(+\mathrm{V}_{\mathrm{S}}\) and sensitivity of Offset to changes in \(-V_{s}\).
Specifications subject to change without notice.

\section*{AC PERFORMANCE CHARACTERISTICS}

These characteristics are included for Design Guidance Only and are not subject to test.
\(+V_{S}=+12 V_{;}-V_{S}=-12 V_{;}+V_{\text {REF }}=+5 V_{;}-V_{R E F}=-5 V\) except where stated.
\begin{tabular}{|c|c|c|c|}
\hline Parameter & Limit & Units & Test Conditions/Comments \\
\hline \multirow[t]{4}{*}{Output Voltage Settling (Time to \(\pm 0.001 \%\) FS For FS Step)} & 5 & \(\mu s\) max & No Load Applied \\
\hline & 3 & \(\mu s\) typ & (DAC output measured from falling edge of \(\overline{\text { LDAC }}\).) \\
\hline & 6 & \(\mu s\) max & \(\mathrm{V}_{\text {OUT }}\) Load \(=1 \mathrm{k} \Omega, \mathrm{C}_{\text {LOAD }}=1000 \mathrm{pF}\). \\
\hline & 4 & \(\mu s t y p\) & (DAC output measured from falling edge of \(\overline{\text { LDAC }}\).) \\
\hline Digital-to-Analog Glitch Impulse & 500 & nV-sec typ & Measured with \(\mathrm{V}_{\mathrm{REF}}=0 \mathrm{~V}\). DAC registers alternatively loaded with input codes of \(8000_{\mathbf{H}}\) and \(0 \mathrm{FFF}_{\mathbf{H}}\) (worst-case transition). Load \(=1 \mathrm{k} \Omega\). \\
\hline Multiplying Feedthrough & -100 & dB max & \[
\begin{aligned}
& +\mathrm{V}_{\mathrm{REF}}=1 \mathrm{~V} \mathrm{rms} 10 \mathrm{kHz} \text { sine wave, } \\
& -\mathrm{V}_{\mathrm{REF}}=0 \mathrm{~V}
\end{aligned}
\] \\
\hline Output Noise Voltage Density ( \(\mathbf{k H z}-1 \mathrm{MHz}\) ) & 40 & \(\mathrm{nV} / \sqrt{\mathrm{Hz}}\) typ & Measured between \(\mathrm{V}_{\text {OUT }}\) and \(-\mathrm{V}_{\text {REF }}\) \\
\hline
\end{tabular}

TIMING CHARACTERISTICS \(\left(+v_{s}=+1 v,-v_{s}=-12 v, v_{m}=24 v, v_{L}=0.4 V, T_{\text {m }}\left(v_{\text {max }}\right)\right.\)



Figure 1. AD569 Timing Diagram-Case A
Figure 2a. AD569 Timing Diagram-Case B


Figure 2b. AD569 Timing Diagram-Case C

\section*{ABSOLUTE MAXIMUM RATINGS*}
( \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) unless otherwise noted)
\(+\mathrm{V}_{\mathbf{S}}(\) Pin 1) to GND (Pin 18) . . . . . . . . + 18V, \(-0.3 \mathrm{~V}\)
- \(\mathrm{V}_{\mathrm{S}}(\) Pin 28) to GND (Pin 18) . . . . . . . . . - 18V, \(+0.3 \mathrm{~V}\)
\(+V_{S}(\operatorname{Pin} 1)\) to \(-V_{S}(\operatorname{Pin} 28) \ldots+26.4 V,-0.3 V\)
Digital Inputs
(Pins 4-14, 19-27) to GND (Pin 18) . . ... \(+V_{s},-0.3 \mathrm{~V}\)
\(+\mathrm{V}_{\text {ReF }}\) Force (Pin 3) to \(+\mathrm{V}_{\text {REF }}\) Sense (Pin 2) . . . \(\pm 16.5 \mathrm{~V}\)
\(-V_{\text {REF }}\) Force (Pin 15) to \(-V_{\text {REF }}\) Sense (Pin 16) . . . \(\pm 16.5 \mathrm{~V}\)
\(\mathbf{V}_{\text {REF }}\) Force (Pins 3, 15) to GND (Pin 18) . . . . . . . . . \(\pm \mathrm{V}_{\mathbf{S}}\)
\(\mathbf{V}_{\text {REF }}\) Sense (Pins 2, 16) to GND (Pin 18) . . . . . . . . . \(\pm \mathrm{V}_{\mathrm{S}}\)
Vout (Pin 17) . . . . . . . . . . . . Indefinite Short to GND Momentary Short to \(+\mathrm{V}_{\mathrm{S}},-\mathrm{V}_{\mathrm{S}}\)


Operating Temperature Range
Commercial Plastic (JN, KN, JP, KP Versions) . 0 to \(+70^{\circ} \mathrm{C}\)
Industrial Ceramic (AD, BD Versions) . . \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
Extended Ceramic (SD Versions) . . . . . \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
Storage Temperature . . . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
*Stresses above those listed under "Absolute Maximum Ratings" may
cause permanent damage to the device. This is a stress rating only and
functional operation of the device at these or any other conditions above
those indicated in the operational sections of this specification is not
implied. Exposure to absolute maximum rating conditions for extended
periods may affect device reliability. periols mattect

\section*{ESD SENSITIVITY}

The AD569 features input protection circuitry consisting of large "distributed" diodes and polysilicon series resistors to dissipate both high-energy discharges (Human Body Model) and fast, low-energy pulses (Charged Device Model). Per Method 3015.2 of MIL-STD-883C, the AD569 has been classified as a Category A device.

Proper ESD precautions are strongly recommended to avoid functional damage or performance degradation. Charges as high as 4000 volts readily accumulate on the human body and test equipment and discharge without detection. Unused devices must be stored in conductive foam or shunts, and the
 foam should be discharged to the destination socket before devices are removed. For further information on ESD precautions, refer to Analog Devices' ESD Prevention Manual.
PIN DESIGNATIONS

ORDERING GUIDE
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Model \({ }^{1}\)} & \multicolumn{2}{|l|}{Integral Nonlinearity} & \multicolumn{2}{|l|}{Differential Nonlinearity} & \multirow[t]{2}{*}{Temperature Range} & \multirow[t]{2}{*}{Package Option \({ }^{2}\)} \\
\hline & \(+25^{\circ} \mathrm{C}\) & \(\mathrm{T}_{\text {min }}-\mathrm{T}_{\text {max }}\) & \(+25^{\circ} \mathrm{C}\) & \(\mathrm{T}_{\text {min }}-\mathrm{T}_{\text {max }}\) & & \\
\hline AD569JN & \(\pm 0.04 \%\) & \(\pm 0.04 \%\) & \(\pm 1 \mathrm{LSB}\) & \(\pm 1 \mathrm{LSB}\) & 0 to \(+70^{\circ} \mathrm{C}\) & N-28 \\
\hline AD569JP & \(\pm 0.04 \%\) & \(\pm 0.04 \%\) & \(\pm 1 \mathrm{LSB}\) & \(\pm 1 \mathrm{LSB}\) & 0 to \(+70^{\circ} \mathrm{C}\) & P-28A \\
\hline AD569KN & \(\pm 0.024 \%\) & \(\pm 0.024 \%\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\pm 1 \mathrm{LSB}\) & 0 to \(+70^{\circ} \mathrm{C}\) & N-28 \\
\hline AD569KP & \(\pm 0.024 \%\) & \(\pm 0.024 \%\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\pm 1\) LSB & 0 to \(+70^{\circ} \mathrm{C}\) & P-28A \\
\hline AD569AD & \(\pm 0.04 \%\) & \(\pm 0.04 \%\) & \(\pm 1 \mathrm{LSB}\) & \(\pm 1 \mathrm{LSB}\) & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & D-28 \\
\hline AD569BD & \(\pm 0.024 \%\) & \(\pm 0.024 \%\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\pm 1 \mathrm{LSB}\) & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & D-28 \\
\hline AD569SD & \(\pm 0.04 \%\) & \(\pm 0.04 \%\) & \(\pm 1\) LSB & \(\pm 1 \mathrm{LSB}\) & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & D-28 \\
\hline
\end{tabular}

\footnotetext{
NOTES
\({ }^{1}\) For details on grade and package offerings screened in accordance with MIL-STD-883, refer to the Analog Devices Military Products Databook or current AD569/883B data sheet.
\({ }^{2} \mathrm{D}=\) Ceramic DIP; N = Plastic DIP; P = Plastic Leaded Chip Carrier. For outline information see Package Information section.
}

Monolithic 16-Bit Serial/Byte DACPORT

AD660

\author{
FEATURES \\ Complete 16-Bit D/A Function \\ On-Chip Output Amplifier \\ On-Chip Buried Zener Voltage Reference \\ \(\pm 1\) LSB Integral Linearity \\ 15-Bit Monotonic over Temperature \\ Microprocessor Compatible \\ Serial or Byte Input \\ Double Buffered Latches \\ Fast ( 40 ns ) Write Pulse \\ \section*{Asynchronous Clear (to 0 V) Function} \\ Serial Output Pin Facilitates Daisy Chaining \\ Unipolar or Bipolar Output \\ Low Glitch: 15 nV-s \\ Low THD+N: 0.009\%
}

\section*{PRODUCT DESCRIPTION}

The AD660 DACPORT \({ }^{\circledR}\) is a complete 16 -bit monolithic D/A converter with an on-board voltage reference, double buffered latches and output amplifier. It is manufactured on Analog Devices' BiMOS II process. This process allows the fabrication of low power CMOS logic functions on the same chip as high precision bipolar linear circuitry.

The AD660's architecture ensures 15-bit monotonicity over time and temperature. Integral and differential nonlinearity is maintained at \(\pm 0.003 \%\) max. The on-chip output amplifier provides a voltage output settling time of \(10 \mu \mathrm{~s}\) to within \(1 / 2\) LSB for a full-scale step.
The AD660 has an extremely flexible digital interface. Data can be loaded into the AD660 in serial mode or as two 8-bit bytes. This is made possible by two digital input pins which have dual functions. The serial mode input format is pin selectable to be MSB or LSB first. The serial output pin allows the user to daisy chain several AD660s by shifting the data through the input latch into the next DAC thus minimizing the number of control lines required to SIN, \(\overline{\mathrm{CS}}\) and LDAC. The byte mode input format is also flexible in that the high byte or low byte data can be loaded first. The double buffered latch structure eliminates data skew errors and provides for simultaneous updating of DACs in a multi-DAC system.
The AD660 is available in five grades. AN and BN versions are specified from \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) and are packaged in a 24 -pin 300 mil plastic DIP. AR and BR versions are also specified from \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) and are packaged in a 24 -pin SOIC. The SQ version is packaged in a 24 -pin 300 mil cerdip package and is also available compliant to MIL-STD-883. Refer to the AD660/ 883B data sheet for specifications and test conditions.

DACPORT is a registered trademark of Analog Devices, Inc.

FUNCTIONAL BLOCK DIAGRAM


\section*{PRODUCT HIGHLIGHTS}
1. The AD660 is a complete 16 -bit DAC , with a voltage reference, double buffered latches and output amplifier on a single chip.
2. The internal buried Zener reference is laser trimmed to 10.000 volts with a \(\pm 0.1 \%\) maximum error and a temperature drift performance of \(\pm 15 \mathrm{ppm} /{ }^{\circ} \mathrm{C}\). The reference is available for external applications.
3. The output range of the AD660 is pin programmable and can be set to provide a unipolar output range of 0 V to +10 V or a bipolar output range of -10 V to +10 V . No external components are required.
4. The AD660 is both dc and ac specified. DC specifications include \(\pm 1\) LSB INL and \(\pm 1\) LSB DNL errors. AC specifications include \(0.009 \%\) THD+N and 83 dB SNR.
5. The double buffered latches on the AD660 eliminate data skew errors and allow simultaneous updating of DACs in multi-DAC applications.
6. The CLEAR function can asynchronously set the output to 0 V regardless of whether the DAC is in unipolar or bipolar mode.
7. The output amplifier settles within \(10 \mu \mathrm{~s}\) to \(\pm 1 / 2\) LSB for a full-scale step and within \(2.5 \mu\) s for a 1 LSB step over temperature. The output glitch is typically 15 nV -s when a fullscale step is loaded.
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Parameter} & \multicolumn{3}{|c|}{AD660AN/AR/SQ} & \multicolumn{3}{|c|}{AD660BN/BR} & \multirow[b]{2}{*}{Units} \\
\hline & Min & Typ & Max & Min & Typ & Max & \\
\hline RESOLUTION & 16 & & & 16 & & & Bits \\
\hline \[
\begin{aligned}
& \left.\hline \text { DIGITAL INPUTS (T } \mathrm{T}_{\text {IN }} \text { to } \mathrm{T}_{\mathrm{MAX}}\right) \\
& \mathrm{V}_{\mathrm{IH}} \text { (Logic "1") } \\
& \mathrm{V}_{\mathrm{II}} \text { (Logic " } 0 \text { ") } \\
& \mathrm{I}_{\mathrm{IH}}\left(\mathrm{~V}_{\mathrm{IH}}=5.5 \mathrm{~V}\right) \\
& \mathrm{I}_{\mathrm{IL}}\left(\mathrm{~V}_{\mathrm{IL}}=0 \mathrm{~V}\right) \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 2.0 \\
& 0
\end{aligned}
\] & & \[
\begin{aligned}
& 5.5 \\
& 0.8 \\
& \pm 10 \\
& \pm 10
\end{aligned}
\] & * & &  & \begin{tabular}{l}
Volts \\
Volts \\
\(\mu \mathrm{A}\) \\
\(\mu \mathrm{A}\)
\end{tabular} \\
\hline \begin{tabular}{l}
TRANSFER FUNCTION CHARACTERISTICS \({ }^{1}\) \\
Integral Nonlinearity \\
\(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) \\
Differential Nonlinearity \\
\(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) \\
Monotonicity Over Temperature \\
Gain Error \({ }^{2,3}\) \\
Gain \(\operatorname{Drift}^{2}\left(T_{\text {MIN }}\right.\) to \(T_{\text {MAX }}\) ) \\
DAC Gain Error \({ }^{4}\) \\
DAC Gain Drift \({ }^{4}\) \\
Unipolar Offset \\
Unipolar Offset Drift ( \(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) ) \\
Bipolar Zero Error \\
Bipolar Zero Error Drift ( \(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) )
\end{tabular} & 14 & & \[
\begin{aligned}
& \pm 2 \\
& \pm 4 \\
& \pm 2 \\
& \pm 4 \\
& \pm 0.10 \\
& 25 \\
& \pm 0.05 \\
& 10 \\
& \pm 2.5 \\
& 3 \\
& \pm 7.5 \\
& 5
\end{aligned}
\] & 15 & & \begin{tabular}{l}
\[
\begin{aligned}
& \pm 1 \\
& \pm 2 \\
& \pm 1 \\
& \pm 2
\end{aligned}
\] \\
15 \\
\(\star\) \\
\(\star\) \\
*
\end{tabular} & \begin{tabular}{l}
LSB \\
LSB \\
LSB \\
LSB \\
Bits \\
\% of FSR \\
\(\mathrm{ppm} /{ }^{\circ} \mathrm{C}\) \\
\(\%\) of FSR \\
ppm \(/{ }^{\circ} \mathrm{C}\) \\
mV \\
ppm \(/{ }^{\circ} \mathrm{C}\) \\
mV \\
\(\mathrm{ppm} /{ }^{\circ} \mathrm{C}\)
\end{tabular} \\
\hline \begin{tabular}{l}
REFERENCE INPUT \\
Input Resistance Bipolar Offset Input Resistance
\end{tabular} & 7 & \[
\begin{aligned}
& 10 \\
& 10
\end{aligned}
\] & \[
\begin{aligned}
& 13 \\
& 13
\end{aligned}
\] & & & & \[
\begin{aligned}
& \mathrm{k} \Omega \\
& \mathrm{k} \Omega \\
& \hline
\end{aligned}
\] \\
\hline \begin{tabular}{l}
REFERENCE OUTPUT \\
Voltage \\
Drift \\
External Current \({ }^{5}\) \\
Capacitive Load \\
Short Circuit Current
\end{tabular} & \[
\begin{aligned}
& 9.99 \\
& 2
\end{aligned}
\] & \[
\begin{aligned}
& 10.00 \\
& 4 \\
& 25
\end{aligned}
\] & \[
\begin{aligned}
& 10.01 \\
& 25 \\
& 1000
\end{aligned}
\] & * & * & \[
15
\] & \begin{tabular}{l}
Volts \\
\(\mathrm{ppm} /{ }^{\circ} \mathrm{C}\) \\
mA \\
pF \\
mA
\end{tabular} \\
\hline \begin{tabular}{l}
OUTPUT CHARACTERISTICS \\
Output Voltage Range \\
Unipolar Configuration \\
Bipolar Configuration \\
Output Current \\
Capacitive Load \\
Short Circuit Current
\end{tabular} & \[
\begin{aligned}
& 0 \\
& -10 \\
& 5
\end{aligned}
\] & 25 & \[
\begin{aligned}
& +10 \\
& +10 \\
& 1000
\end{aligned}
\] & * \({ }_{\text {* }}\) & * &  & \begin{tabular}{l}
Volts \\
Volts \\
mA \\
pF \\
mA
\end{tabular} \\
\hline POWER SUPPLIES
\[
\begin{gathered}
\text { Voltage } \\
\mathrm{V}_{\mathrm{CC}}{ }^{6} \\
\mathrm{~V}_{\mathrm{EE}}{ }^{6} \\
\mathrm{~V}_{\mathrm{LL}}
\end{gathered}
\] & \[
\begin{aligned}
& +13.5 \\
& -13.5 \\
& +4.5
\end{aligned}
\] & & \[
\begin{aligned}
& +16.5 \\
& -16.5 \\
& +5.5
\end{aligned}
\] &  & & * & \begin{tabular}{l}
Volts \\
Volts \\
Volts
\end{tabular} \\
\hline \begin{tabular}{l}
Current (No Load) \\
\(\mathrm{I}_{\mathrm{CC}}\) \\
\(I_{E E}\) \\
\(\mathrm{I}_{\mathrm{LL}}\) \\
\(@ V_{\mathrm{IH}}, \mathrm{V}_{\mathrm{IL}}=5,0 \mathrm{~V}\) \\
@ \(\mathrm{V}_{\mathrm{IH}}, \mathrm{V}_{\mathrm{IL}}=2.4,0.4 \mathrm{~V}\) \\
Power Supply Sensitivity \\
Power Dissipation (Static, No Load)
\end{tabular} & & \[
\begin{aligned}
& +12 \\
& -12 \\
& \\
& 0.3 \\
& 3 \\
& 1 \\
& 365
\end{aligned}
\] & \[
\begin{aligned}
& +18 \\
& -18 \\
& 2 \\
& 7.5 \\
& 2 \\
& 625
\end{aligned}
\] & & *
*
*
*
* &  & \begin{tabular}{l}
mA \\
mA \\
mA \\
mA \\
ppm/\% \\
mW
\end{tabular} \\
\hline \begin{tabular}{l}
TEMPERATURE RANGE \\
Specified Performance (A, B) Specified Performance (S)
\end{tabular} & \[
\begin{aligned}
& -40 \\
& -55
\end{aligned}
\] & & \[
\begin{aligned}
& +85 \\
& +125
\end{aligned}
\] & * & & * & \[
\begin{aligned}
& { }^{\circ} \mathrm{C} \\
& { }^{\circ} \mathrm{C}
\end{aligned}
\] \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) For 16-bit resolution, \(1 \mathrm{LSB}=0.0015 \%\) of FSR. For 15 -bit resolution, \(1 \mathrm{LSB}=0.003 \%\) of FSR. For 14 -bit resolution,
1 LSB \(=0.006 \%\) of FSR. FSR stands for Full-Scale Range and is 10 V in a Unipolar Mode and 20 V in Bipolar Mode.
\({ }^{2}\) Gain error and gain drift are measured using the internal reference. The internal reference is the main contributor to gain drift, If lower gain drift is required, the AD660 can be used with a precision external reference such as the AD587, AD586 or AD688.
\({ }^{3}\) Gain Error is measured with fixed \(50 \Omega\) resistors as shown in the Application section. Eliminating these resistors increases the gain error by \(0.25 \%\) of FSR (Unipolar mode) or \(0.50 \%\) of FSR (Bipolar mode).
\({ }^{4}\) DAC Gain Error and Drift are measured with an external voltage reference. They represent the error contributed by the DAC alone, for use with an external reference.
\({ }^{5}\) External current is defined as the current available in addition to that supplied to REF IN and SPAN/BIPOLAR OFFSET on the AD660.
\({ }^{6}\) Operation on \(\pm 12 \mathrm{~V}\) supplies is possible using an external reference such as the AD586 and reducing the output range. Refer to the Interna//External Reference section.
*Indicates that the specification is the same as AD660AN/AR/SQ.
Specifications subject to change without notice.

AC PERFORMANCE CHARACTERISTICS (With the exception of Total Harmonic Distortion + Noise and Signal-to-Noise Ratio, these characteristics are included for design guidance only and are not subject to test. THD \(+N\) and SNR are \(100 \%\) tested.
\(\mathrm{T}_{\text {MIN }} \leq \mathrm{T}_{\mathrm{A}} \leq \mathrm{T}_{\text {max }}, \mathrm{V}_{\mathrm{Cc}}=+15 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-15 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=+5 \mathrm{~V}\) except where noted.)
\begin{tabular}{|c|c|c|c|}
\hline Parameter & Limit & Units & Test Conditions/Comments \\
\hline Output Settling Time (Time to \(\pm 0.0008 \%\) FS with \(2 \mathrm{k} \Omega, 1000 \mathrm{pF}\) Load) & \[
\begin{aligned}
& 13 \\
& 8 \\
& 10 \\
& 6 \\
& 8 \\
& 2.5
\end{aligned}
\] & \(\mu \mathrm{s}\) max \(\mu \mathrm{s}\) typ \(\mu \mathrm{s}\) typ \(\mu \mathrm{styp}\) \(\mu \mathrm{s}\) typ \(\mu \mathrm{s}\) typ & \[
\begin{aligned}
& 20 \mathrm{~V} \text { Step, } \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\
& 20 \mathrm{~V} \text { Step, } \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\
& 20 \mathrm{~V} \text { Step, } \mathrm{T}_{\text {MIN }} \leq \mathrm{T}_{\mathrm{A}} \leq \mathrm{T}_{\text {MAX }} \\
& 10 \mathrm{~V} \text { Step, } \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\
& 10 \text { V Step, } \mathrm{T}_{\text {MIN }} \leq \mathrm{T}_{\mathrm{A}} \leq \mathrm{T}_{\text {MAX }} \\
& 1 \text { LSB Step, } \mathrm{T}_{\text {MIN }} \leq \mathrm{T}_{\mathrm{A}} \leq \mathrm{T}_{\text {MAX }}
\end{aligned}
\] \\
\hline ```
Total Harmonic Distortion + Noise
    A, B, S Grade
    A, B, S Grade
    A, B, S Grade
``` & \[
\begin{aligned}
& 0.009 \\
& 0.056 \\
& 5.6
\end{aligned}
\] & \begin{tabular}{l}
\% max \\
\% max \\
\% max
\end{tabular} & \(0 \mathrm{~dB}, 990.5 \mathrm{~Hz}\); Sample Rate \(=96 \mathrm{kHz} ; \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) \(-20 \mathrm{~dB}, 990.5 \mathrm{~Hz}\); Sample Rate \(=96 \mathrm{kHz} ; \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) \(-60 \mathrm{~dB}, 990.5 \mathrm{~Hz}\); Sample Rate \(=96 \mathrm{kHz} ; \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) \\
\hline Signal-to-Noise Ratio & 83 & dB min & \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) \\
\hline Digital-to-Analog Glitch Impulse & 15 & nV-s typ & DAC Alternately Loaded with \(8000_{\mathrm{H}}\) and \(7 \mathrm{FFF}_{\mathrm{H}}\) \\
\hline Digital Feedthrough & 2 & nV-s typ & DAC Alternately Loaded with \(0000_{\mathrm{H}}\) and \(\mathrm{FFFF}_{\mathrm{H}} ; \overline{\mathrm{CS}}\) High \\
\hline Output Noise Voltage Density ( \(1 \mathrm{kHz}-1 \mathrm{MHz}\) ) & 120 & nV/Rt Hz typ & Measured at \(\mathrm{V}_{\text {OUT }}, 20 \mathrm{~V}\) Span; Excludes Reference \\
\hline Reference Noise & 125 & nV/Rt Hz typ & Measured at REF OUT \\
\hline
\end{tabular}

Specifications subject to change without notice.

\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD660 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


ABSOLUTE MAXIMUM RATINGS*


PIN CONFIGURATION


ORDERING GUIDE
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline Model & Temperature Range & Linearity Error Max
\[
+25^{\circ} \mathrm{C}
\] & Linearity Error Max
\[
\mathbf{T}_{\text {MIN }}-\mathbf{T}_{\text {MAX }}
\] & Gain TC max ppm \(/{ }^{\circ} \mathrm{C}\) & Package Description & Package Option \({ }^{\star}\) \\
\hline AD660AN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 2\) LSB & \(\pm 4\) LSB & 25 & Plastic DIP & N-28 \\
\hline AD660AR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 2\) LSB & \(\pm 4\) LSB & 25 & SOIC & R-28 \\
\hline AD660BN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1\) LSB & \(\pm 2\) LSB & 15 & Plastic DIP & N-28 \\
\hline AD660BR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1\) LSB & \(\pm 2\) LSB & 15 & SOIC & R-28 \\
\hline AD660SQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 2\) LSB & \(\pm 4\) LSB & 25 & Cerdip & Q-28 \\
\hline AD660SQ/883B** & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 2\) LSB & ** & ** & ** & ** \\
\hline
\end{tabular}
\(\star \mathrm{N}=\) Plastic DIP; \(\mathrm{Q}=\) Cerdip; R = SOIC. For outline information see Package Information section.
\(\star \star\) Refer to AD660/883B military data sheet.
TIMING CHARACTERISTICS \(v_{c c}=+15, v, v_{t i}=-15, v, v_{u}=+5, v, v_{11}=24, v, v_{0}=0.4 v\)
\begin{tabular}{|c|c|c|c|}
\hline Parameter & Limit \(+25^{\circ} \mathrm{C}\) & Limit \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & Units \\
\hline (Figure 1a) & & & \\
\hline \(\mathrm{t}_{\mathrm{Cs}}\) & 40 & 50 & \(n s \min\) \\
\hline \(t_{\text {ds }}\) & 40 & 50 & \(n \mathrm{nmin}\) \\
\hline \(\mathrm{t}_{\text {DH }}\) & 0 & 10 & ns min \\
\hline \(\mathrm{t}_{\text {BES }}\) & 40 & 50 & ns min \\
\hline \(\mathrm{t}_{\text {BEH }}\) & 0 & 10 & ns min \\
\hline \(\mathrm{t}_{\text {LH }}\) & 80 & 100 & ns min \\
\hline \(\mathrm{t}_{\text {LW }}\) & 40 & 50 & ns min \\
\hline (Figure 1b) & & & \\
\hline \(\mathrm{t}_{\text {CLK }}\) & 80 & 100 & ns min \\
\hline \(\mathrm{t}_{\text {LO }}\) & 30 & 50 & ns min \\
\hline \(\mathrm{t}_{\mathrm{HI}}\) & 30 & 50 & ns min \\
\hline \(\mathrm{t}_{\text {ss }}\) & 0 & 10 & ns min \\
\hline \(\mathrm{t}_{\mathrm{DS}}\) & 40 & 50 & ns min \\
\hline \(\mathrm{t}_{\mathrm{DH}}\) & 0 & 10 & ns min \\
\hline \(\mathrm{t}_{\text {SH }}\) & 0 & 10 & \(n \mathrm{nmin}\) \\
\hline \(\mathrm{t}_{\text {LH }}\) & 80 & 100 & ns min \\
\hline \(\mathrm{t}_{\text {Lw }}\) & 40 & 50 & ns min \\
\hline (Figure 1c) & & & \\
\hline t \(\overline{\text { CLR }}\) & 80 & 110 & ns min \\
\hline \(\mathrm{t}_{\text {SET }}\) & 80 & 110 & ns min \\
\hline \(\mathrm{t}_{\text {HOLD }}\) & 0 & 10 & ns min \\
\hline (Figure 1d) & & & \\
\hline \(\mathrm{t}_{\text {PROP }}\) & 50 & 100 & ns min \\
\hline \(\mathrm{t}_{\text {DS }}\) & 50 & 80 & ns min \\
\hline
\end{tabular}

Specifications subject to change without notice.


Figure 1a. AD660 Byte Load Timing


Figure 1b. AD660 Serial Load Timing


Figure 1c. Asynchronous Clear to Bipolar or Unipolar Zero


Figure 1d. Serial Out Timing

\section*{DEFINITIONS OF SPECIFICATIONS}

INTEGRAL NONLINEARITY: Analog Devices defines integral nonlinearity as the maximum deviation of the actual, adjusted DAC output from the ideal analog output (a straight line drawn from 0 to FS-1 LSB) for any bit combination. This is also referred to as relative accuracy.
DIFFERENTIAL NONLINEARITY: Differential nonlinearity is the measure of the change in the analog output, normalized to full scale, associated with a 1 LSB change in the digital input code. Monotonic behavior requires that the differential linearity error be greater than or equal to -1 LSB over the temperature range of interest.
MONOTONICITY: A DAC is monotonic if the output either increases or remains constant for increasing digital inputs with the result that the output will always be a singie-vaiued function of the input.
GAIN ERROR: Gain error is a measure of the output error between an ideal DAC and the actual device output with all 1s loaded after offset error has been adjusted out.
OFFSET ERROR: Offset error is a combination of the offset errors of the voltage-mode DAC and the output amplifier and is measured with all Os loaded in the DAC.

BIPOLAR ZERO ERROR: When the AD660 is connected for bipolar output and \(10 \ldots 000\) is loaded in the DAC, the deviation of the analog output from the ideal midscale value of 0 V is called the bipolar zero error.
DRIFT: Drift is the change in a parameter (such as gain, offset and bipolar zero) over a specified temperature range. The drift temperature coefficient, specified in \(\mathrm{ppm} /{ }^{\circ} \mathrm{C}\), is calculated by measuring the parameter at \(\mathrm{T}_{\text {MIN }}, 25^{\circ} \mathrm{C}\) and \(\mathrm{T}_{\text {MAX }}\) and dividing the change in the parameter by the corresponding temperature change.
TOTAL HARMONIC DISTORTION + NOISE: Total harmonic distortion + noise (THD +N ) is defined as the ratio of the square root of the sum of the squares of the values of the harmonics and noise to the value of the fundamental input frequency. It is usualiy expressed in percent (\%).
THD +N is a measure of the magnitude and distribution of linearity error, differential linearity error, quantization error and noise. The distribution of these errors may be different, depending upon the amplitude of the output signal. Therefore, to be the most useful, THD +N should be specified for both large and small signal amplitudes.

SIGNAL-TO-NOISE RATIO: The signal-to-noise ratio is defined as the ratio of the amplitude of the output when a fullscale signal is present to the output with no signal present. This is measured in dB .

DIGITAL-TO-ANALOG GLITCH IMPULSE: This is the amount of charge injected from the digital inputs to the analog output when the inputs change state. This is measured at half scale when the DAC switches around the MSB and as many as possible switches change state, i.e., from 011 . . 111 to 100 . . 000.
DIGITAL FEEDTHROUGH: When the DAC is not selected (i.e., \(\overline{\mathrm{CS}}\) is held high), high frequency logic activity on the digital inputs is capacitively coupled through the device to show up as noise on the \(V_{\text {OUt }}\) pin. This noise is digital feedthrough.

\section*{THEORY OF OPERATION}

The AD660 uses an array of bipolar current sources with MOS current steering switches to develop a current proportional to the applied digital word, ranging from 0 to 2 mA . A segmented architecture is used, where the most significant four data bits are thermometer decoded to drive 15 equal current sources. The lesser bits are scaled using a R-2R ladder, then applied together with the segmented sources to the summing node of the output amplifier. The internal span/bipolar offset resistor can be connected to the DAC output to provide a 0 V to +10 V span, or it can be connected to the reference input to provide a -10 V to +10 V span.


Figure 2. AD660 Functional Block Diagram

\section*{ANALOG CIRCUIT CONNECTIONS}

Internal scaling resistors provided in the AD660 may be connected to produce a unipolar output range of 0 V to +10 V or a bipolar output range of -10 V to +10 V . Gain and offset drift are minimized in the AD660 because of the thermal tracking of the scaling resistors with other device components.

\section*{UNIPOLAR CONFIGURATION}

The configuration shown in Figure 3a will provide a unipolar 0 V to +10 V output range. In this mode, \(50 \Omega\) resistors are tied between the span/bipolar offset terminal (Pin 22) and \(\mathrm{V}_{\text {OUT }}\)
(Pin 21), and between REF OUT (Pin 24) and REF IN (Pin 23). It is possible to use the AD660 without any external components by tying Pin 24 directly to Pin 23 and Pin 22 directly to Pin 21. Eliminating these resistors will increase the gain error by \(0.25 \%\) of FSR.


Figure 3a. 0 V to +10 V Unipolar Voltage Output
If it is desired to adjust the gain and offset errors to zero, this can be accomplished using the circuit shown in Figure 3b. The adjustment procedure is as follows:
STEP1 . . . ZERO ADJUST
Turn all bits OFF and adjust zero trimmer, R4, until the output reads 0.000000 volts ( \(1 \mathrm{LSB}=153 \mu \mathrm{~V}\) ).
STEP 2 . . . GAIN ADJUST
Turn all bits ON and adjust gain trimmer, R1, until the output is 9.999847 volts. (Full scale is adjusted to 1 LSB less than the nominal full scale of 10.000000 volts).

Figure 3b. 0 V to +10 V Unipolar Voltage Output with Gain and Offset Adjustment


\section*{AD660}

\section*{BIPOLAR CONFIGURATION}

The circuit shown in Figure 4a will provide a bipolar output voltage from -10.000000 V to +9.999694 V with positive full scale occurring with all bits ON. As in the unipolar mode, resistors R1 and R2 may be eliminated altogether to provide AD660 bipolar operation without any external components. Eliminating these resistors will increase the gain error by \(0.50 \%\) of FSR in the bipolar mode.


Figure 4a. \(\pm 10\) V Bipolar Voltage Output
Gain offset and bipolar zero errors can be adjusted to zero using the circuit shown in Figure \(4 b\) as follows:
STEP I . . . OFFSET ADJUST
Turn OFF all bits. Adjust trimmer R2 to give -10.000000 volts output.

\section*{STEP II . . . GAIN ADJUST}

Turn all bits ON and adjust R1 to give a reading of +9.999694 volts.
STEP III . . . BIPOLAR ZERO ADJUST (Optional)
In applications where an accurate zero output is required, set the MSB ON, all other bits OFF, and readjust R2 for zero volts output.


Figure 4b. \(\pm 10\) V Bipolar Voltage Output with Gain and Offset Adjustment

It should be noted that using external resistors will introduce a small temperature drift component beyond that inherent in the AD660. The internal resistors are trimmed to ratio-match and temperature-track other resistors on chip, even though their absolute tolerances are \(\pm 20 \%\) and absolute temperature coefficients are approximately \(-50 \mathrm{ppm} /{ }^{\circ} \mathrm{C}\). In the case that external resistors are used, the temperature coefficient mismatch between internal and external resistors, multiplied by the sensitivity of the circuit to variations in the external resistor value, will be the resultant additional temperature drift.

\section*{INTERNAL/EXTERNAL REFERENCE USE}

The AD660 has an internal low noise buried Zener diode reference which is trimmed for absolute accuracy and temperature coefficient. This reference is buffered and optimized for use in a high speed DAC and will give long-term stability equal or superior to the best discrete Zener diode references. The performance of the AD660 is specified with the internal reference driving the DAC and with the DAC alone (for use with a precision external reference ).
The internal reference has sufficient buffering to drive external circuitry in addition to the reference currents required for the DAC (typically 1 mA to REF IN and 1 mA to BIPOLAR OFFSET). A minimum of 2 mA is available for driving external loads. The AD660 reference output should be buffered with an external op amp if it is required to supply more than 4 mA total current. The reference is tested and guaranteed to \(\pm 0.2 \% \max\) error.
It is also possible to use external references other than 10 volts with slightly degraded linearity specifications. The recommended range of reference voltages is +5 V to +10.24 V , which allows \(5 \mathrm{~V}, 8.192 \mathrm{~V}\) and 10.24 V ranges to be used. For example, by using the AD5865 V reference, outputs of 0 V to +5 V unipolar or \(\pm 5 \mathrm{~V}\) bipolar can be realized. Using the AD586 voltage reference makes it possible to operate the AD660 with \(\pm 12 \mathrm{~V}\) supplies with \(10 \%\) tolerances.

Figure 5 shows the AD660 using the AD586 precision 5 V reference in the bipolar configuration. The highest grade AD586MN is specified with a drift of \(2 \mathrm{ppm} /{ }^{\circ} \mathrm{C}\) which is a \(7.5 \times\) improvement over the AD660's internal reference. This circuit includes two optional potentiometers and one optional resistor that can be used to adjust the gain, offset and bipolar zero errors in a manner similar to that described in the BIPOLAR CONFIGURATION section. Use -5.000000 V and +4.999847 as the output values.

The AD660 can also be used with the AD587 10 V reference, using the same configuration shown in Figure 5 to produce a \(\pm 10 \mathrm{~V}\) output. The highest grade AD587LR, N is specified at 5 \(\mathrm{ppm} /{ }^{\circ} \mathrm{C}\), which is a \(3 \times\) improvement over the AD660's internal reference.
Figure 6 shows the AD660 using the AD680 precision \(\pm 10 \mathrm{~V}\) reference, in the unipolar configuration. The highest grade AD688BQ is specified with a temperature coefficient of \(1.5 \mathrm{ppm} /{ }^{\circ} \mathrm{C}\). The \(\pm 10 \mathrm{~V}\) output is also ideal for providing precise biasing for the offset trim resistor R4.


Figure 5. Using the AD660 with the AD586 5 V Reference


Figure 6. Using the AD660 with the AD688 High Precision \(\pm 10 \mathrm{~V}\) Reference

\section*{OUTPUT SETTLING AND GLITCH}

The AD660's output buffer amplifier typically settles to within \(0.0008 \%\) FS ( \(1 / 2 \mathrm{LSB}\) ) of its final value in \(8 \mu \mathrm{~s}\) for a full-scale step. Figures 7 a and 7 b show settling for a full-scale and an LSB step, respectively, with a \(2 \mathrm{k} \Omega, 1000 \mathrm{pF}\) load applied. The guaranteed maximum settling time at \(+25^{\circ} \mathrm{C}\) for a full-scale step is \(13 \mu \mathrm{~s}\) with this load. The typical settling time for a 1 LSB step is \(2.5 \mu \mathrm{~s}\).

The digital-to-analog glitch impulse is specified as 15 nV -s typical. Figure 7c shows the typical glitch impulse characteristic at the code 011 . . 111 to \(100 \ldots 000\) transition when loading the second rank register from the first rank register.


Figure 7. Output Characteristics

\section*{DIGITAL CIRCUIT DETAILS}

The AD660 has several "dual-use" pins which allow flexible operation while maintaining the lowest possible pin count and consequently the smallest package size. The user should, therefore, pay careful attention to the following information when applying the AD660.
Data can be loaded into the AD660 in serial or byte mode as described below.
Serial Mode Operation is enabled by bringing \(\overline{\text { SER }}\) (Pin 17), low. This changes the function of DB0 (Pin 12) to that of the serial input pin, SIN. It also changes the function of DB1 (Pin 11) to a control input that tells the AD660 whether the serial data is going to be loaded MSB or \(\overline{\mathrm{LSB}}\) first.
In serial mode \(\overline{\mathrm{HBE}}\) and \(\overline{\mathrm{LBE}}\) are effectively disabled except for \(\overline{\text { LBE's }}\) dual function which is to control whether the user wishes to have the asynchronous clear function go to unipolar or bipolar zero. (A low on \(\overline{\mathrm{LBE}}\), when \(\overline{\mathrm{CLR}}\) is strobed, sends the DAC output to unipolar zero, a high to bipolar zero.) The AD660 does not care about the status of HBE when in serial mode.
Data is clocked into the input register on the rising edge of \(\overline{\mathrm{CS}}\) as shown in Figure lb. The data is then resident in the first rank latch and can be loaded into the DAC latch by taking LDAC high. This will cause the DAC to change to the appropriate output value.

It should be noted that the clear function clears the DAC latch but does not clear the first rank latch. Therefore, the data that was previously resident in the first rank latch can be reloaded simply by bringing LDAC high after the event that necessitated \(\overline{\text { CLR }}\) to be strobed has ended. Alternatively, new data can be loaded into the first rank latch if desired.

The serial out pin (SOUT) can be used to daisy chain several DACs together in multi-DAC applications to minimize the number of isolators being used to cross an intrinsic safety barrier.
The first rank latch simply acts like a 16 -bit shift register, and repeated strobing of \(\overline{C S}\) will shift the data out through SOUT and into the next DAC. Each DAC in the chain will require its own LDAC signal unless all of the DACs are to be updated simultaneously.
Byte Mode Operation is enabled simply by keeping SER high, which configures DB0-DB7 as data inputs. In this mode \(\overline{\mathrm{HBE}}\) and \(\overline{\mathrm{LBE}}\) are used to identify the data as either the high byte or low byte of the 16 -bit input word. (The user can load the data, in any order, into the first rank latch.) As in the serial mode case, the status of \(\overline{\mathrm{LBE}}\), when \(\overline{\mathrm{CLR}}\) is strobed determines whether the AD660 clears to unipolar or bipolar zero. Therefore, when in byte mode, the user must take care to set \(\overline{\mathrm{LBE}}\) to the desired status before strobing \(\overline{\text { CLR }}\). (In serial mode the user can simply hardware \(\overline{\mathrm{LBE}}\) to the desired state.)
NOTE: \(\overline{\mathrm{CS}}\) is edge triggered. \(\overline{\mathrm{HBE}}, \overline{\mathrm{LBE}}\) and LDAC are level triggered.

AD660 TO MC68HC11 (SPI BUS) INTERFACE The AD660 interface to the Motorola SPI (serial peripheral interface) is shown in Figure 8. The MOSI, SCK, and \(\overline{\text { SS }}\) pins of the \(\mathrm{HCl1}\) are respectively connected to the BIT0, \(\overline{\mathrm{CS}}\) and LDAC pins of the AD660. The SER pin of the AD660 is tied low causing the first rank latch to be transparent. The majority of the interfacing issues are taken care of in the software initialization. A typical routine such as the one shown below begins by initializing the state of the various SPI data and control registers.

The most significant data byte (MSBY) is then retrieved from memory and processed by the SENDAT subroutine. The \(\overline{\mathrm{SS}}\) pin is driven low by indexing into the PORTD data register and clear Bit 5. This causes the 2nd rank latch of the AD660 to become transparent. The MSBY is then set to the SPI data register where it is automatically transferred to the AD660.

The HCll generates the requisite 8 clock pulses with data valid on the rising edges. After the most significant byte is transmitted, the least significant byte (LSBY) is loaded from memory and transmitted in a similar fashion. To complete the transfer, the LDAC pin is driven high latching the complete 16 -bit word into the AD660.
\begin{tabular}{|c|c|c|}
\hline \multirow[t]{6}{*}{INIT} & LDAA \#\$2F & \(; \overline{\mathrm{SS}}=1 ; \mathrm{SCK}=0 ; \mathrm{MOSI}=1\) \\
\hline & STAA PORTD & ;SEND TO SPI OUTPUTS \\
\hline & LDAA \#\$38 & ;SS, SCK,MOSI = OUTPUTS \\
\hline & STAA DDRD & ;SEND DATA DIRECTION INFO \\
\hline & LDAA \#\$50 & ;DABL INTRPTS,SPI IS MASTER \& ON \\
\hline & STAA SPCR & ; \(\mathrm{CPOL}=0, \mathrm{CPHA}=0,1 \mathrm{MHZ}\) BAUD RATE \\
\hline \multirow[t]{3}{*}{NEXTPT} & LDAA MSBY & ;LOAD ACCUM W/UPPER 8 BITS \\
\hline & BSR SENDAT & ;JUMP TO DAC OUTPUT ROUTINE \\
\hline & JMP NEXTPT & ;INFINITE LOOP \\
\hline \multirow[t]{3}{*}{SENDAT} & LDY \#\$1000 & ;POINT AT ON-CHIP REGISTERS \\
\hline & BCLR \$08, Y ,\$20 & ;DRIVE SS (LDAC) LOW \\
\hline & STAA SPDR & ;SEND MS-BYTE TO SPI DATA REG \\
\hline \multirow[t]{4}{*}{WAIT1} & LDAA SPSR & ;CHECK STATUS OF SPIE \\
\hline & BPL WAIT1 & ;POLL FOR END OF X-MISSION \\
\hline & LDAA LSBY & ;GET LOW 8 BITS FROM MEMORY \\
\hline & STAA SPDR & ;SEND LS-BYTE TO SPI DATA REG \\
\hline \multirow[t]{4}{*}{WAIT2} & LDAA SPSR & ;CHECK STATUS OF SPIE \\
\hline & BPL WAIT2 & ;POLL FOR END OF X-MISSION \\
\hline & BSET \$08,Y,\$20 & ;DRIV SS HIGH TO LATCH DATA \\
\hline & RTS & \\
\hline
\end{tabular}


Figure 8. AD660 to 68HC11 (SPI) Interface

\section*{AD660 TO MICROWIRE INTERFACE}

The flexible serial interface of the AD660 is also compatible with the National Semiconductor MICROWIRE \({ }^{\text {TM }}\) interface. The MICROWIRE interface is used on microcontrollers such as the COP400 and COP800 series of processors. A generic interface to the MICROWIRE interface is shown in Figure 9. The G1, SK, And SO pins of the MICROWIRE interface are respectively connected to the LDAC, \(\overline{\mathrm{CS}}\) and BIT0 pins of the AD660.

MICROWIRE is a registered trademark of National Semiconductor.


Figure 9. AD660 to MICROWIRE Interface

\section*{AD660 TO ADSP-210x FAMILY INTERFACE}

The serial mode of the AD660 minimizes the number of control and data lines required to interface to digital signal processors (DSPs) such as the ADSP-210x family. The application in Figure 10 shows the interface between an ADSP-2101 and the AD660. Both the TFS pin and the DT pins of the ADSP-2101 should be connected to the \(\overline{\mathrm{SER}}\) and BIT0 pins of the AD660, respectively. An inverter is required between the SCLK output and the \(\overline{\mathrm{CS}}\) input of the AD660 in order to assure that data transmitted to the BIT0 pin is valid on the rising edge of \(\overline{\mathrm{CS}}\).
The serial port (SPORT) of the DSP should be configured for alternate framing mode so that TFS complies with the wordlength framing requirement of \(\overline{\mathrm{SER}}\). Note that the INVTFS bit in the SPORT control register should be set to invert the TFS signal so that \(\overline{\mathrm{SER}}\) is the correct polarity. The LDAC signal, which must meet the minimum hold specification of \(\mathrm{t}_{\mathrm{IH}}\), is easily generated by delaying the rising edge of \(\overline{\mathrm{SER}}\) with a 74 HC 74 flip-flop. The \(\overline{\mathrm{CS}}\) signal clocks the flip-flop resulting in a delay of approximately one \(\overline{\mathrm{CS}}\) clock cycle.
In applications such as waveform generation, accurate timing of the output samples is important to avoid noise that would be induced by jitter on the LDAC signal. In this example, the ADSP-2101 is set up to use the internal timer to interrupt the processor at the precise and desired sample rate. When the timer interrupt occurs, the processors's 16 -bit data word is written to the transmit register (TXn). This causes the DSP to automatically generate the TFS signal and begin transmission of the data.


Figure 10. AD660 to ADSP-210x Interface

\section*{AD660 TO Z80 INTERFACE}

Figure 11 shows a Zilog Z-80 8-bit microprocessor connected to the AD660 using the byte mode interface. The double-buffered capability of the AD660 allows the microprocessor to independently write to the low and high byte registers, and update the DAC output. Processor speeds up to 6 MHz on Z-80B require no extra wait states to interface with the AD660 using a 74ALS138 as the address decoder.

\section*{AD660-Applications Information}

The address decoder analyzes the input-output address produced by the processor to select the function to be performed by the AD660, qualified by the coincidence of the Input-Output Request (IORQ*) and Write (WR^) pins. The least significant address bit (A0) determines if the low or high byte register of the AD660 is active. More significant address bits select between input register loading, DAC output update, and unipolar or bipolar clear.
A typical Z-80 software routine begins by writing the low byte of the desired 16 -bit DAC data to address 0 , followed by the high byte to address 1. The DAC output is then updated by activating LDAC with a write to address 2 (or 3 ). A clear to unipolar zero occurs on a write to address 4 , and a clear to bipolar zero is performed by a write to address 5 . The actual data written to addresses 2 through 5 is irrelevant. The decoder can easily be expanded to control as many AD660s as required.


Figure 11. Connections for 8-Bit Bus Interface

\section*{NOISE}

In high resolution systems, noise is often the limiting factor. A 16-bit DAC with a 10 volt span has an LSB size of \(153 \mu \mathrm{~V}\) ( -96 dB ). Therefore, the noise floor must remain below this level in the frequency range of interest. The AD660's noise spectral density is shown in Figures 12 and 13. Figure 12 shows the DAC output noise voltage spectral density for a 20 V span excluding the reference. This figure shows the \(1 / \mathrm{f}\) corner frequency at 100 Hz and the wideband noise to be below \(120 \mathrm{nV} / \sqrt{\mathrm{Hz}}\). Figure 13 shows the reference noise voltage spectral density. This figure shows the reference wideband noise to be below \(125 \mathrm{nV} / \sqrt{\mathrm{Hz}}\).


Figure 12. DAC Output Noise Voltage Spectral Density


Figure 13. Reference Noise Voltage Spectral Density

\section*{BOARD LAYOUT}

Designing with high resolution data converters requires careful attention to board layout. Trace impedance is the first issue. A \(306 \mu \mathrm{~A}\) current through a \(0.5 \Omega\) trace will develop a voltage drop of \(153 \mu \mathrm{~V}\), which is 1 LSB at the 16 -bit level for a 10 V full-scale span. In addition to ground drops, inductive and capacitive coupling need to be considered, especially when high accuracy analog signals share the same board with digital signals. Finally, power supplies need to be decoupled in order to filter out ac noise.

Analog and digital signals should not share a common path. Each signal should have an appropriate analog or digital return routed close to it. Using this approach, signal loops enclose a small area, minimizing the inductive coupling of noise. Wide PC tracks, large gauge wire, and ground planes are highly recommended to provide low impedance signal paths. Separate analog and digital ground planes should also be used, with a single interconnection point to minimize ground loops. Analog signals should be routed as far as possible from digital signals and should cross them at right angles.
One feature that the AD660 incorporates to help the user layout is that the analog pins ( \(\mathrm{V}_{\mathrm{CC}}, \mathrm{V}_{\mathrm{EE}}\), REF OUT, REF IN, SPAN/ BIP OFFSET, \(V_{\text {OUT }}\) and AGND) are adjacent to help isolate analog signals from digital signals.

\section*{SUPPLY DECOUPLING}

The AD660 power supplies should be well filtered, well regulated, and free from high frequency noise. Switching power supplies are not recommended due to their tendency to generate spikes which can induce noise in the analog system.
Decoupling capacitors should be used in very close layout proximity between all power supply pins and ground. A \(10 \mu \mathrm{~F}\) tantalum capacitor in parallel with a \(0.1 \mu \mathrm{~F}\) ceramic capacitor provides adequate decoupling. \(\mathrm{V}_{\mathrm{CC}}\) and \(\mathrm{V}_{\mathrm{EE}}\) should be bypassed to analog ground, while \(\mathrm{V}_{\mathrm{LL}}\) should be decoupled to digital ground.
An effort should be made to minimize the trace length between the capacitor leads and the respective converter power supply and common pins. The circuit layout should attempt to locate the AD660, associated analog circuitry and interconnections as far as possible from logic circuitry. A solid analog ground plane around the AD660 will isolate large switching ground currents. For these reasons, the use of wire wrap circuit construction is not recommended; careful printed circuit construction is preferred.

\section*{GROUNDING}

The AD660 has two pins, designated analog ground (AGND) and digital ground (DGND.) The analog ground pin is the "high quality" ground reference point for the device. Any external loads on the output of the AD660 should be returned to ana\(\log\) ground. If an external reference is used, this should also be returned to the analog ground.
If a single AD660 is used with separate analog and digital ground planes, connect the analog ground plane to AGND and
the digital ground plane to DGND keeping lead lengths as short as possible. Then connect AGND and DGND together at the AD660. If multiple AD660s are used or the AD660 shares ana\(\log\) supplies with other components, connect the analog and digital returns together once at the power supplies rather than at each chip. This single interconnection of grounds prevents large ground loops and consequently prevents digital currents from flowing through the analog ground. Monolithic

FEATURES
Four Complete Voltage Output DACs
Data Register Readback Feature
"Reset to Zero" Override
Multiplying Operation
Double-Buffered Latches
Surface Mount and DIP Packages
MIL-STD-883 Compliant Versions Available
APPLICATIONS
Automatic Test Equipment Robotics
Process Control
Disk Drives
Instrumentation
Avionics

\section*{PRODUCT DESCRIPTION}

The AD664 is four complete 12 -bit, voltage-output DACs on one monolithic IC chip. Each DAC has a double-buffered input latch structure and a data readback function. All DAC read and write operations occur through a single microprocessor-compatible I/O port.
The I/O port accommodates 4-, 8- or 12-bit parallel words allowing simple interfacing with a wide variety of microprocessors. A reset to zero control pin is provided to allow a user to simultaneously reset all DAC outputs to zero, regardless of the contents of the input latch. Any one or all of the DACs may be placed in a transparent mode allowing immediate response by the outputs to the input data.
The analog portion of the AD664 consists of four DAC cells, four output amplifiers, a control amplifier and switches. Each DAC cell is an inverting R-2R type. The output current from each DAC is switched to the on-board application resistors and output amplifier. The output range of each DAC cell is programmed through the digital I/O port and may be set to unipolar or bipolar range, with a gain of one or two times the reference voltage. All DACs are operated from a single external reference.
The functional completeness of the AD664 results from the combination of Analog Devices' BiMOS II process, laser-trimmed thin-film resistors and double-level metal interconnects.

\section*{PRODUCT HIGHLIGHTS}
1. The AD664 provides four voltage-output DACs on one chip offering the highest density 12 -bit D/A function available.
2. The output range of each DAC is fully and independently programmable.
3. Readback capability allows verification of contents of the internal data registers.

\section*{PIN CONFIGURATIONS}


28-Pin DIP Package

4. The asynchronous RESET control returns all D/A outputs to zero volts.
5. DAC-to-DAC matching performance is specified and tested.
6. Linearity error is specified to be \(1 / 2 \mathrm{LSB}\) at room temperature and \(3 / 4 \mathrm{LSB}\) maximum for the \(\mathrm{K}, \mathrm{B}\) and T grades.
7. DAC performance is guaranteed to be monotonic over the full operating temperature range.
8. Readback buffers have tristate outputs.
9. Multiplying-mode operation allows use with fixed or variable, positive or negative external references.
10. The AD664 is available in versions compliant with MIL-STD-883. Refer to the Analog Devices Military Products Databook or current AD664/883B data sheet for detailed specifications.

SPEGFEGTONG \(\begin{aligned} & \left(V_{U}=+5 V, V_{C C}=+15 V, ~\right. \\ & \text { unless otherwise noted) }\end{aligned}\)


AD664
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Model} & \multicolumn{3}{|c|}{JN/JP/AD/AJ/SD} & \multicolumn{3}{|r|}{KN/KP/BD/BJ/BE/TD/TE} & \multirow[b]{2}{*}{Units} \\
\hline & Min & Typ & Max & Min & Typ & Max & \\
\hline \multicolumn{8}{|l|}{DIGITAL INPUTS} \\
\hline \(\mathrm{V}_{\text {IH }}\) & 2.0 & & & * & & & Volts \\
\hline \(\mathrm{V}_{\text {IL }}\) & 0 & & 0.8 & * & & * & Volts \\
\hline \multicolumn{8}{|l|}{Data Inputs} \\
\hline \(\mathrm{I}_{1 \mathrm{H}}\) ( \(\mathrm{V}_{\text {IN }}=\mathrm{V}_{\mathrm{LL}}\) & -10 & \(\pm 1\) & 10 & * & * & * & \(\mu \mathrm{A}\) \\
\hline \(\mathrm{I}_{\mathrm{IL}}\) @ \(\mathrm{V}_{\mathrm{IN}}=\) DGND & -10 & \(\pm 1\) & 10 & * & * & * & \(\mu \mathrm{A}\) \\
\hline \multicolumn{8}{|l|}{\(\overline{\mathrm{CS}} / \mathrm{DS} 0 / \mathrm{DS} 1 / \overline{\mathrm{RST}} / \overline{\mathrm{RD}} / \overline{\mathrm{LS}}\)} \\
\hline \(\mathrm{I}_{\mathrm{IH}}\) @ \(\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{LL}}\) & -10 & \(\pm 1\) & 10 & * & * & * & \(\mu \mathrm{A}\) \\
\hline \(\mathrm{I}_{\mathrm{IH}}\) @ \(\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{LL}}\) & -10 & \(\pm 1\) & 10 & * & * & * & \(\mu \mathrm{A}\) \\
\hline \multicolumn{8}{|l|}{\[
\mathrm{MS} / \mathrm{TR}^{12}
\]} \\
\hline \(\mathrm{I}_{\mathrm{IH}}\) @ \(\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{LL}}\) & -10 & 5 & 10 & * & * & * & \(\mu \mathrm{A}\) \\
\hline \(\mathrm{I}_{\text {IL }}\) @ \(\mathrm{V}_{\text {IN }}=\mathrm{DGND}\) & -10 & -5 & 0 & * & * & * & \(\mu \mathrm{A}\) \\
\hline \multicolumn{8}{|l|}{\(\overline{\mathrm{QS}} / \overline{\mathrm{QS1}} / \overline{\mathrm{QS2}}{ }^{12} \mathrm{~V}\)} \\
\hline \(\mathrm{I}_{\mathrm{IH}}\) @ \(\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{LL}}\) & -10 & 5 & 10 & * & * & * & \(\mu \mathrm{A}\) \\
\hline \(\mathrm{I}_{\mathrm{IL}}\) © \(\mathrm{V}_{\mathrm{IN}}=\) DGND & -10 & \(\pm 1\) & 10 & * & * & * & \(\mu \mathrm{A}\) \\
\hline \multicolumn{8}{|l|}{DIGITAL OUTPUTS} \\
\hline \(\mathrm{V}_{\text {OL }}\) @ 1.6 mA Sink & & & 0.4 & & & * & Volts \\
\hline \(\mathrm{V}_{\mathrm{OH}}\) @ 0.5 mA Source & 2.4 & & & * & & & Volts \\
\hline \multicolumn{8}{|l|}{TEMPERATURE RANGE} \\
\hline JN/JP/KN/KP & 0 & & +70 & * & & * & \({ }^{\circ} \mathrm{C}\) \\
\hline AD/AJ/BD/BJ/BE & -40 & & +85 & * & & * & \({ }^{\circ} \mathrm{C}\) \\
\hline SD/TD/TE & -55 & & +125 & * & & * & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1} \mathrm{~A}\) minimum power supply of \(\pm 12.0 \mathrm{~V}\) is required for 0 to +10 V and \(\pm 10 \mathrm{~V}\) operation. A minimum power supply of \(\pm 11.4 \mathrm{~V}\) is required for -5 V to
+5 V operation.
\({ }^{2} \mathrm{For} \mathrm{V}_{\mathrm{CC}}<12 \mathrm{~V}\) and \(\mathrm{V}_{\mathrm{EE}}>-12 \mathrm{~V}\). Voltage not to exceed 10 V maximum.
\({ }^{3}\) Bipolar zero error is the difference from the ideal output ( 0 volts) and the actual output voltage with code 100000000000 applied to the inputs.
\({ }^{4}\) Linearity error is defined as the maximum deviation of the actual DAC output from the ideal output (a straight line drawn from 0 to F.S. -1LSB).
\({ }^{5} \mathrm{FSR}\) means Full-Scale Range and is 20 V for \(\pm 10 \mathrm{~V}\) range and 10 V for \(\pm 5 \mathrm{~V}\) range.
\({ }^{6} \mathrm{~A}\) minimum power supply of \(\pm 12.0 \mathrm{~V}\) is required for a 10 V reference voltage.
\({ }^{7}\) Analog Ground Current is input code dependent.
\({ }^{8}\) Gain error matching is the largest difference in gain error between any two DACs in one package.
\({ }^{9}\) Offset error matching is the largest difference in offset error between any two DACs in one package.
\({ }^{10}\) Bipolar zero error matching is the largest difference in bipolar zero error between any two DACs in one package.
\({ }^{11}\) Linearity error matching is the difference in the worst case linearity error between any two DACs in one package.
\({ }^{12} 44\)-pin versions only.
*Specifications same as JN/JP/AD/AJ/SD.
Specifications subject to change without notice.
Specifications shown in boldface are tested on all production units at final electrical test. Results from those test are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.

\section*{ABSOLUTE MAXIMUM RATINGS*}
(Specifications apply to all grades except where noted.)
V \({ }_{L L}\) to DGND . . . . . . . . . . . . . . . . . . . . . . . . . 0 to +7 V
\(V_{\text {CC }}\) to \({ }^{\text {DGND }}\). . . . . . . . . . . . . . . . . . . . . . . . 0 to +18 V
V \(_{\text {EE }}\) to DGND . . . . . . . . . . . . . . . . . . . . . . . - 18 V to 0 O
Soldering . . . . . . . . . . . . . . . . . . . . . . . . . \(+300^{\circ} \mathrm{C}\), 10 sec
Power Dissipation . . . . . . . . . . . . . . . . . . . . . . . . . 1000mW
AGND to DGND . . . . . . . . . . . . . . . . . . . . . - \(1 V\) to +1V
Reference Input . . . . . . . . . . . . . \(\mathrm{V}_{\mathrm{REF}} \leq \pm 10 \mathrm{~V}\) and \(\mathrm{V}_{\mathrm{REF}}\) \(\leq\left(\mathrm{V}_{\mathrm{CC}}-2 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}+2 \mathrm{~V}\right)\)


Digital Inputs
Analog Outputs . . -0.3 V to +7 V
. Indefinite Shorts to \(\mathrm{V}_{\mathrm{CC}} ; \mathrm{V}_{\mathrm{LL}}, \mathrm{V}_{\mathrm{EE}}\) and GND

\footnotetext{
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
}

\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are removed.



\section*{FUNCTIONAL DESCRIPTION}

The AD664 combines four complete 12-bit voltage output D/A converters with a fast, flexible digital input/output port on one monolithic chip. It is available in two forms, a 44-pin version shown in Figure la and a 28 -pin version shown in Figure 1b.

\section*{44-Pin Versions}

Each DAC offers flexibility, accuracy and good dynamic performance. The R-2R structure is fabricated from thin-film resistors which are laser-trimmed to achieve 1/2LSB linearity and guaranteed monotonicity. The output amplifier combines the best features of the bipolar and MOS devices to achieve good dynamic performance and low offset. Settling time is under \(10 \mu \mathrm{~s}\) and each output can drive a \(5 \mathrm{~mA}, 500 \mathrm{pF}\) load. Short-circuit protection allows indefinite shorts to \(\mathrm{V}_{\mathrm{LL}}, \mathrm{V}_{\mathrm{CC}}, \mathrm{V}_{\mathrm{EE}}\) and GND. The output and span resistor pins are available separately. This feature allows a user to insert current-boosting elements to increase the drive capability of the system, as well as to overcome parasitics.
Digital circuitry is implemented in CMOS logic. The fast, low power, digital interface allows the AD664 to be interfaced with most microprocessors. Through this interface, the wide variety of features on each chip may be accessed. For example, the input data for each DAC is programmed by way of \(4-, 8\)-, 12 or 16 -bit words. The double-buffered input structure of this latch allows all four DACs to be updated simultaneously. A readback feature allows the internal registers to be read back through the same digital port, as either 4-, 8 - or 12 -bit words. When disabled, the readback drivers are placed in a high impedance (tristate) mode. A TRANSPARENT mode allows the input data to pass straight through both ranks of input registers and appear at the DAC with a minimum of delay. One D/A may be placed in the transparent mode at a time, or all four may be made transparent at once. The MODE SELECT feature allows the output range and mode of the DACs to be selected via the data bus inputs. An internal mode select register stores the selections. This register may also be read back to check its contents. A RESET-TO-ZERO feature allows all DACs to be reset to 0 volts out by strobing a single pin.


Figure 1b. 28-Pin Block Diagram

\section*{28-Pin Versions}

The 28-pin versions are dedicated versions of the 44-pin AD664. Each offers a reduced set of features from those offered in the 44-pin version. This accommodates the reduced number of package pins available. Data is written and read with 12 -bit words only. Output range and mode select functions are also not available in 28 -pin versions. As an alternative, users specify either the UNI (unipolar, 0 to \(\mathrm{V}_{\text {REF }}\) ) models or the BIP (bipolar, \(-\mathrm{V}_{\text {REF }}\) to \(\mathbf{V}_{\text {REF }}\) ) models depending on the application requirements. Finally, the transparent mode is not available on the \(\mathbf{2 8}\)-pin versions.

Table I. Transfer Functions
\begin{tabular}{l|l|l} 
& \multicolumn{1}{|c|}{ Mode \(=\) UNI } & \multicolumn{1}{c}{ Mode \(=\) BIP } \\
\hline \multirow{3}{*}{ Gain = 1} & \(000000000000=0 \mathrm{~V}\) & \(000000000000=-\mathrm{V}_{\text {REF }} / 2\) \\
& \(100000000000=\mathrm{V}_{\text {REF }} / 2\) & \(100000000000=0 \mathrm{~V}\) \\
& \(111111111111=\mathrm{V}_{\text {REF }}-1 \mathrm{LSB}\) & \(11111111111=\mathrm{V}_{\text {REF }} / 2-1 \mathrm{LSB}\) \\
\hline & \(000000000000=0 \mathrm{~V}\) & \(000000000000=-\mathrm{V}_{\text {REF }}\) \\
Gain = & \(100000000000=\mathrm{V}_{\text {REF }}\) & \(10000000000=0 \mathrm{~V}\) \\
& \(11111111111=2 \times \mathrm{V}_{\text {REF }}-1 \mathrm{LSB}\) & \(11111111111=+\mathrm{V}_{\text {REF }}-1 \mathrm{LSB}\) \\
\hline
\end{tabular}

ORDERING GUIDE
\begin{tabular}{|c|c|c|c|c|c|}
\hline Model \({ }^{1}\) & Temperature Range & Output Range & \begin{tabular}{l}
Gain \\
Error
\end{tabular} & \begin{tabular}{l}
Linearity \\
Error
\end{tabular} & Package Options \({ }^{2}\) \\
\hline AD664JN-UNI & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & 0 to \(+\mathrm{V}_{\mathrm{R}}\) & \(\pm 7 \mathrm{LSB}\) & \(\pm 0.75 \mathrm{LSB}\) & N-28 \\
\hline AD664JN-BIP & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & \(-\mathrm{V}_{\text {REF }}\) to \(+\mathrm{V}_{\text {REF }}\) & \(\pm 7 \mathrm{LSB}\) & \(\pm 0.75 \mathrm{LSB}\) & \(\mathrm{N}-28\) \\
\hline AD664JP & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & Programmable & \(\pm 7 \mathrm{LSB}\) & \(\pm 0.75 \mathrm{LSB}\) & P-44A \\
\hline AD664KN-UNI & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & 0 to \(+\mathrm{V}_{\text {REF }}\) & \(\pm 5\) LSB & \(\pm 0.5 \mathrm{LSB}\) & N-28 \\
\hline AD664KN-BIP & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & \(-\mathrm{V}_{\text {REF }}\) to \(+\mathrm{V}_{\text {REF }}\) & \(\pm 5\) LSB & \(\pm 0.5 \mathrm{LSB}\) & \(\mathrm{N}-28\) \\
\hline AD664KP & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & Programmable & \(\pm 5 \mathrm{LSB}\) & \(\pm 0.5 \mathrm{LSB}\) & P-44A \\
\hline AD664AD-UNI & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 0 to \(+\mathrm{V}_{\text {REF }}\) & \(\pm 7 \mathrm{LSB}\) & \(\pm 0.75 \mathrm{LSB}\) & D-28 \\
\hline AD664AD-BIP & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(-\mathrm{V}_{\text {REF }}\) to \(+\mathrm{V}_{\text {REF }}\) & \(\pm 7 \mathrm{LSB}\) & \(\pm 0.75 \mathrm{LSB}\) & D-28 \\
\hline AD664AJ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & Programmable & \(\pm 7 \mathrm{LSB}\) & \(\pm 0.75 \mathrm{LSB}\) & J-44 \\
\hline AD664BD-UNI & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 0 to \(+\mathrm{V}_{\text {REF }}\) & \(\pm 5 \mathrm{LSB}\) & \(\pm 0.5 \mathrm{LSB}\) & D-28 \\
\hline AD664BD-BIP & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(-\mathrm{V}_{\text {REF }}\) to \(+\mathrm{V}_{\text {REF }}\) & \(\pm 5\) LSB & \(\pm 0.5 \mathrm{LSB}\) & D-28 \\
\hline AD664BJ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & Programmable & \(\pm 5 \mathrm{LSB}\) & \(\pm 0.5 \mathrm{LSB}\) & J-44 \\
\hline AD664BE & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & Programmable & \(\pm 5 \mathrm{LSB}\) & \(\pm 0.5 \mathrm{LSB}\) & E-44A \\
\hline AD664SD-UNI & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 0 to \(+\mathrm{V}_{\text {REF }}\) & \(\pm 7 \mathrm{LSB}\) & \(\pm 0.75 \mathrm{LSB}\) & D-28 \\
\hline AD664SD-BIP & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(-\mathrm{V}_{\text {REF }}\) to \(+\mathrm{V}_{\text {REF }}\) & \(\pm 7 \mathrm{LSB}\) & \(\pm 0.75 \mathrm{LSB}\) & D-28 \\
\hline AD664TD-UNI & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 0 to \(+\mathrm{V}_{\text {REF }}\) & \(\pm 5 \mathrm{LSB}\) & \(\pm 0.5 \mathrm{LSB}\) & D-28 \\
\hline AD664TD-BIP & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(-\mathrm{V}_{\text {REF }}\) to \(+\mathrm{V}_{\text {REF }}\) & \(\pm 5\) LSB & \(\pm 0.5 \mathrm{LSB}\) & D-28 \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) For details on grade and package offerings screened in accordance with MIL-STD-883, refer to the Analog Devices Military Products Databook or current AD664/883B data sheet.
\({ }^{2} \mathrm{D}=\) Ceramic DIP; E = Leadless Ceramic Chip Carrier; J = Leaded Chip Carrier; \(\mathrm{N}=\) Plastic DIP;
\(\mathbf{P}=\) Plastic Leaded Chip Carrier. For outline information see Package Information section.


\section*{FEATURES}

\author{
Complete 12-Bit D/A Function Double-Buffered Latch On Chip Output Amplifier High Stability Buried Zener Reference \\ Single Chip Construction \\ Monotonicity Guaranteed Over Temperature \\ Linearity Guaranteed Over Temperature: 1/2LSB max \\ Settling Time: 3 \(\mu \mathrm{s}\) max to 0.01\% \\ Guaranteed for Operation with \(\pm 12 \mathrm{~V}\) or \(\pm 15 \mathrm{~V}\) Supplies \\ Low Power: \(\mathbf{3 0 0} \mathbf{m W}\) Including Reference \\ TTL/5V CMOS Compatible Logic Inputs \\ Low Logic Input Currents \\ MIL-STD-883 Compliant Versions Available
}

\section*{PRODUCT DESCRIPTION}

The AD667 is a complete voltage output 12-bit digital-to-analog converter including a high stability buried Zener voltage reference and double-buffered input latch on a single chip. The converter uses 12 precision high speed bipolar current steering switches and a laser trimmed thin film resistor network to provide fast settling time and high accuracy.
Microprocessor compatibility is achieved by the on-chip doublebuffered latch. The design of the input latch allows direct interface to 4 -, 8 -, 12 -, or 16 -bit buses. The 12 bits of data from the first rank of latches can then be transferred to the second rank, avoiding generation of spurious analog output values. The latch responds to strobe pulses as short as 100 ns , allowing use with the fastest available microprocessors.
The functional completeness and high performance in the AD667 results from a combination of advanced switch design, high speed bipolar manufacturing process, and the proven laser wafertrimming (LWT) technology. The AD667 is trimmed at the wafer level and is specified to \(\pm 1 / 4 \mathrm{LSB}\) maximum linearity error ( \(\mathrm{K}, \mathrm{B}\) grades) at \(25^{\circ} \mathrm{C}\) and \(\pm 1 / 2 \mathrm{LSB}\) over the full operating temperature range.
The subsurface (buried) Zener diode on the chip provides a low-noise voltage reference which has long-term stability and temperature drift characteristics comparable to the best discrete reference diodes. The laser trimming process which provides the excellent linearity, is also used to trim the absolute value of the reference as well as its temperature coefficient. The AD667 is thus well suited for wide temperature range performance with \(\pm 1 / 2\) LSB maximum linearity error and guaranteed monotonicity over the full temperature range. Typical full scale gain T.C. is \(5 \mathrm{ppm} /{ }^{\circ} \mathrm{C}\).

\footnotetext{
*Protected by Patent Numbers 3,803,590; 3,890,611; 3,932,863; 3,978,473; 4,020,486; and others pending.
}

FUNCTIONAL BLOCK DIAGRAM


The AD667 is available in five performance grades. The AD667J and K are specified for use over the 0 to \(+70^{\circ} \mathrm{C}\) temperature range and are available in a 28 -pin molded plastic DIP (N) or PLCC ( P ) package. The AD667S grade is specified for the \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) range and is available in the ceramic DIP (D) or LCC (E) package. The AD667A and B are specified for use over the \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) temperature range and are available in a 28 -pin hermetically sealed ceramic DIP (D) package.

\section*{PRODUCT HIGHLIGHTS}
1. The AD667 is a complete voltage output DAC with voltage reference and digital latches on a single IC chip.
2. The double-buffered latch structure permits direct interface to 4 -, 8 -, 12 -, or 16 -bit data buses. All logic inputs are TTL or 5 volt CMOS compatible.
3. The internal buried Zener reference is laser-trimmed to \(\mathbf{1 0 . 0 0}\) volts with a \(\pm 1 \%\) maximum error. The reference voltage is also available for external application.
4. The gain setting and bipolar offset resistors are matched to the internal ladder network to guarantee a low gain temperature coefficient and are laser-trimmed for minimum full scale and bipolar offset errors.
5. The precision high speed current steering switch and on-board high speed output amplifier settle within \(1 / 2 \mathrm{LSB}\) for a 10 V full scale transition in \(2.0 \mu\) s when properly compensated.
6. The AD667 is available in versions compliant with MIL-STD883. Refer to the Analog Devices Military Products Databook or current AD667/883B data sheet for detailed specifications.

AD667
-SPECIFICATIONS
\(\left(T_{A}=+25^{\circ} \mathrm{C}, \pm 12 \mathrm{~V} . \pm 15 \mathrm{~V}\right.\) power supplies unless otherwise noted.)


\section*{NOTES}
\({ }^{1}\) The digital input specifications are \(100 \%\) tested at \(+25^{\circ} \mathrm{C}\), and guaranteed but not tested over the full temperature range.
\({ }^{2}\) Adjustable to zero.
\({ }^{3}\) FSR means "Full Scale Range" and is 20 V for \(\pm 10 \mathrm{~V}\) range and 10 V for the \(\pm 5 \mathrm{~V}\) range.
\({ }^{4} \mathrm{~A}\) minimum power supply of \(\pm 12.5 \mathrm{~V}\) is required for a \(\pm 10 \mathrm{~V}\) full scale output and \(\pm 11.4 \mathrm{~V}\) is required for all other voltage ranges.
Specifications subject to change without notice.
Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.

\section*{TIMING SPECIFICATIONS}
(All Models, \(\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=+12 \mathrm{~V}\) or +15 V , \(\mathrm{V}_{\mathrm{EE}}=-12 \mathrm{~V}\) or -15 V )
\begin{tabular}{llllll} 
Symbol & Parameter & Min & Typ & Max & \\
\(\mathbf{t}_{\mathrm{DC}}\) & Data Valid to End of \(\overline{\mathrm{CS}}\) & 50 & - & - & ns \\
\(\mathbf{t}_{\mathrm{AC}}\) & Address Valid to End of \(\overline{\mathrm{CS}}\) & 100 & - & - & ns \\
\(\mathbf{t}_{\mathrm{CP}}\) & \(\overline{\mathrm{CS}}\) Pulse Width & 100 & - & - & ns \\
\(\mathbf{t}_{\mathrm{DH}}\) & Data Hold Time & 0 & - & - & ns \\
\(\mathbf{t}_{\text {SETT }}\) & Output Voltage Settling Time & - & 2 & 4 & \(\mu \mathrm{~S}\)
\end{tabular}
ABSOLUTE MAXIMUM RATINGS
\(V_{\text {cc }}\) to Power Ground ..... 0 V to +18 V
\(V_{\text {EE }}\) to Power Ground ..... OV tó -18 V
Digital Inputs (Pins 11-15, 17-28)
to Power Ground ..... -1.0 V to +7.0 V
Ref In to Reference Ground ..... \(\pm 12 \mathrm{~V}\)
Bipolar Offset to Reference Ground ..... \(\pm 12 \mathrm{~V}\)
10V Span R to Reference Ground ..... \(\pm 12 \mathrm{~V}\)
20V Span R to Reference Ground ..... \(\pm 24 \mathrm{~V}\)
Ref Out, Vout (Pins 6, 9) . . Indefinite short to power groundMomentary Short to \(\mathrm{V}_{\mathrm{CC}}\)
Power Dissipation 1000 mW
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|}
\hline Model & Min & \[
\begin{aligned}
& \text { AD667A } \\
& \text { Typ }
\end{aligned}
\] & Max & Min & \[
\begin{aligned}
& \text { AD667B } \\
& \text { Typ }
\end{aligned}
\] & Max & Min & \[
\begin{aligned}
& \text { AD667S } \\
& \text { Typ }
\end{aligned}
\] & Max & Units \\
\hline ```
DIGITAL INPUTS
    Resolution
    Logic Levels(TTLCompatible, T Tmin - T max (1
        VIH
        V IL (Logic "0")
        I
        IIL}(\mp@subsup{V}{IL}{}=0.8\textrm{V}
``` & \({ }_{0}^{+2.0}\) & 3
1 & \[
\begin{aligned}
& 12 \\
& +5.5 \\
& +0.8 \\
& 10 \\
& 5
\end{aligned}
\] & \({ }_{0}^{+2.0}\) & \[
\begin{aligned}
& 3 \\
& 1
\end{aligned}
\] & \[
\begin{aligned}
& 12 \\
& +5.5 \\
& +0.8 \\
& 10 \\
& 5
\end{aligned}
\] & \({ }_{0}^{+2.0}\) & 3
1 & \[
\begin{aligned}
& 12 \\
& +5.5 \\
& +0.7 \\
& 10 \\
& 5
\end{aligned}
\] & \begin{tabular}{l}
Bits \\
V \\
V \\
\(\mu \mathrm{A}\) \\
\(\mu \mathrm{A}\)
\end{tabular} \\
\hline \begin{tabular}{l}
TRANSFER CHARACTERISTICS \\
ACCURACY \\
Linearity Error @ + \(25^{\circ} \mathrm{C}\)
\[
\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\min } \text { to } \mathrm{T}_{\text {max }}
\] \\
Differential Linearity Error @ \(+25^{\circ} \mathrm{C}\)
\[
\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\min } \text { to } \mathrm{T}_{\max }
\] \\
Gain Error \({ }^{2}\) \\
Unipolar Offset Error \({ }^{2}\) \\
Bipolar Zero \({ }^{2}\)
\end{tabular} & Mono & \[
\begin{aligned}
& \pm 1 / 4 \\
& \pm 1 / 2 \\
& \pm 1 / 2 \\
& \text { icity } \mathbf{G u} \\
& \pm 0.1 \\
& \pm 1 \\
& \pm 0.05
\end{aligned}
\] & \[
\begin{gathered}
\pm 1 / 2 \\
\pm 3 / 4 \\
\pm 3 / 4 \\
\text { anteed } \\
\pm 0.2 \\
\pm 2 \\
\pm 0.1
\end{gathered}
\] & Mono & \[
\begin{aligned}
& \pm 1 / 8 \\
& \pm 1 / 4 \\
& \pm 1 / 4 \\
& \text { icity Gus } \\
& \pm 0.1 \\
& \pm 1 \\
& \pm 0.05
\end{aligned}
\] & \[
\begin{aligned}
& \pm 1 / 4 \\
& \pm 1 / 2 \\
& \pm 1 / 2 \\
& \text { anteed } \\
& \pm 0.2 \\
& \pm 2 \\
& \pm 0.1
\end{aligned}
\] & Mon & \[
\begin{aligned}
& \pm 1 / 8 \\
& \pm 1 / 2 \\
& \pm 1 / 4 \\
& \text { icity } \mathbf{G u} \\
& \pm 0.1 \\
& \pm 1 \\
& \pm 0.05
\end{aligned}
\] & \[
\begin{gathered}
\pm 1 / 2 \\
\pm 3 / 4 \\
\pm 3 / 4 \\
\text { anteed } \\
\pm 0.2 \\
\pm 2 \\
\pm 0.1
\end{gathered}
\] & \begin{tabular}{l}
LSB \\
LSB \\
LSB \\
LSB \\
\(\%\) of FSR \({ }^{3}\) \\
LSB \\
\% of FSR
\end{tabular} \\
\hline \begin{tabular}{l}
DRIFT \\
Differential Linearity \\
Gain (Full Scale) \(\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\) to \(\mathrm{T}_{\text {min }}\) or \(\mathrm{T}_{\text {max }}\) \\
Unipolar Offset \(\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\) to \(\mathrm{T}_{\text {min }}\) or \(\mathrm{T}_{\text {max }}\) \\
Bipolar Zero \(\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\) to \(\mathrm{T}_{\text {min }}\) or \(\mathrm{T}_{\text {max }}\)
\end{tabular} & & \[
\begin{aligned}
& \pm 2 \\
& \pm 5 \\
& \pm 1 \\
& \pm 5
\end{aligned}
\] & \[
\begin{aligned}
& \pm 30 \\
& \pm 3 \\
& \pm 10
\end{aligned}
\] & & \[
\begin{aligned}
& \pm 2 \\
& \pm 5
\end{aligned}
\] & \[
\begin{aligned}
& \pm 15 \\
& \pm 3 \\
& \pm 10
\end{aligned}
\] & & \[
\begin{aligned}
& \pm 2 \\
& \pm 15
\end{aligned}
\] & \[
\begin{aligned}
& \pm 30 \\
& \pm 3 \\
& \pm 10
\end{aligned}
\] & \begin{tabular}{l}
ppm of \(\mathrm{FSR}^{\circ} \mathrm{C}\) \\
ppm of FSR \(/{ }^{\circ} \mathrm{C}\) \\
ppm of FSR \(/{ }^{\circ} \mathrm{C}\) \\
ppm of FSR \(/{ }^{\circ} \mathrm{C}\)
\end{tabular} \\
\hline \begin{tabular}{l}
CONVERSION SPEED \\
Settling Time to \(\pm \mathbf{0 . 0 1 \%}\) of FSR for FSR change ( \(2 \mathrm{k} \Omega \| 500 \mathrm{pF}\) load) with \(10 k \Omega\) Feedback with \(5 \mathrm{k} \Omega\) Feedback \\
For LSB Change Slew Rate
\end{tabular} & 10 & \[
\begin{aligned}
& 3 \\
& 2 \\
& 1
\end{aligned}
\] & 4
3 & 10 & \[
\begin{aligned}
& 3 \\
& 2 \\
& 1
\end{aligned}
\] & \[
\begin{array}{r}
4 \\
3
\end{array}
\] & 10 & \[
\begin{aligned}
& 3 \\
& 2 \\
& 1
\end{aligned}
\] & \[
\begin{aligned}
& 4 \\
& 3
\end{aligned}
\] & \begin{tabular}{l}
\(\mu \mathrm{s}\) \\
\(\mu \mathrm{s}\) \\
\(\mu \mathrm{s}\) V/ \(\mu \mathrm{s}\)
\end{tabular} \\
\hline \begin{tabular}{l}
ANALOGOUTPUT Ranges \({ }^{4}\) \\
Output Current Output Impedance (dc) Short Circuit Current
\end{tabular} & \(\pm 5\) & \[
\begin{aligned}
& 2.5, \pm 5 \\
& 5,+10 \\
& 0.05
\end{aligned}
\] & 10
40 & \(\pm 5\) & \[
\begin{aligned}
& \pm 2.5, \pm 5, \pm 10, \\
& +5,+10
\end{aligned}
\] & 10
40 & \multicolumn{3}{|r|}{\[
\begin{aligned}
& \pm 2.5, \pm 5, \pm 10, \\
& +5,+10
\end{aligned}
\]} & \begin{tabular}{l}
V \\
mA \\
\(\Omega\) \\
mA
\end{tabular} \\
\hline REFERENCEOUTPUT External Current & \[
\begin{aligned}
& 9.90 \\
& 0.1
\end{aligned}
\] & \[
\begin{aligned}
& 10.00 \\
& 1.0
\end{aligned}
\] & 10.10 & \[
\begin{aligned}
& 9.90 \\
& 0.1
\end{aligned}
\] & \[
\begin{aligned}
& 10.00 \\
& 1.0
\end{aligned}
\] & 10.10 & \[
\begin{aligned}
& 9.90 \\
& 0.1
\end{aligned}
\] & \[
\begin{aligned}
& 10.00 \\
& 1.0
\end{aligned}
\] & 10.10 & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{~mA}
\end{aligned}
\] \\
\hline POWER SUPPLY SENSITIVITY
\[
\begin{aligned}
& \mathrm{V}_{\mathrm{CC}}=+11.4 \text { to }+16.5 \mathrm{~V} \mathrm{dc} \\
& \mathrm{~V}_{\mathrm{EE}}=-11.4 \text { to }-16.5 \mathrm{~V} \mathrm{dc}
\end{aligned}
\] & & \[
\begin{aligned}
& 5 \\
& 5
\end{aligned}
\] & \[
\begin{aligned}
& 10 \\
& 10
\end{aligned}
\] & & \[
\begin{aligned}
& 5 \\
& 5
\end{aligned}
\] & \[
\begin{aligned}
& 10 \\
& 10
\end{aligned}
\] & & \[
\begin{aligned}
& 5 \\
& 5
\end{aligned}
\] & \[
\begin{aligned}
& 10 \\
& 10
\end{aligned}
\] & ppm of FS/\% ppm of FS/\% \\
\hline ```
POWER SUPPLY REQUIREMENTS
    Rated Voltages
    Range4
    Supply Current
        +11.4 to +16.5V dc
        -11.4 to -16.5V dc
``` & \(\pm 11.4\) & \[
\begin{aligned}
& 12, \pm 15 \\
& 8 \\
& 20
\end{aligned}
\] & \[
\begin{aligned}
& \pm 16.5 \\
& 12 \\
& 25
\end{aligned}
\] & \(\pm 11.4\) & \[
\begin{aligned}
& 12, \pm 15 \\
& 8 \\
& 20 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \pm 16.5 \\
& 12 \\
& 25 \\
& \hline
\end{aligned}
\] & \(\pm 11.4\) & \[
\begin{aligned}
& 12, \pm 15 \\
& 8 \\
& 20 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \pm 16.5 \\
& 12 \\
& 25
\end{aligned}
\] & \begin{tabular}{l}
V
V \\
mA mA
\end{tabular} \\
\hline \begin{tabular}{l}
TEMPERATURERANGE \\
Specification Storage
\end{tabular} & \[
\begin{aligned}
& -25 \\
& -65
\end{aligned}
\] & & \[
\begin{aligned}
& +85 \\
& +150
\end{aligned}
\] & \multicolumn{2}{|l|}{-25} & \[
\begin{aligned}
& +85 \\
& +150
\end{aligned}
\] & \multicolumn{2}{|l|}{-55} & \[
\begin{aligned}
& +125 \\
& +150
\end{aligned}
\] & \[
\begin{aligned}
& { }^{\circ} \mathrm{C} \\
& { }^{\circ} \mathrm{C}
\end{aligned}
\] \\
\hline
\end{tabular}

\section*{TIMING DIAGRAMS}

WRITE CYCLE \# 1
(Load First Rank from Data Bus; A3 = 1)


WRITE CYCLE \#2
(Load Second Rank from First Rank; A2, A1, A0=1)


\section*{PIN CONNECTIONS}


\section*{THE AD667 OFFERS TRUE 12-BIT PERFORMANCE OVER THE FULL TEMPERATURE RANGE}

LINEARITY ERROR: Analog Devices defines linearity error as the maximum deviation of the actual, adjusted DAC output from the ideal analog output (a straight line drawn from 0 to F.S. - 1LSB) for any bit combination. The AD667 is laser trimmed to \(1 / 4\) LSB ( \(0.006 \%\) of \(F\).S.) maximum error at \(+25^{\circ} \mathrm{C}\) for the \(K\) and \(B\) versions and \(1 / 2 L S B\) for the \(J, A\) and \(S\) versions.
MONOTONICITY: A DAC is said to be monotonic if the output either increases or remains constant for increasing digital inputs such that the output will always be a nondecreasing function of input. All versions of the AD667 are monotonic over their full operating temperature range.

DIFFERENTIAL NONLINEARITY: Monotonic behavior requires that the differential linearity error be less than 1LSB both at \(+25^{\circ} \mathrm{C}\) and over the temperature range of interest. Differential nonlinearity is the measure of the variation in analog value, normalized to full scale, associated with a 1LSB change in digital input code. For example, for a 10 volt full scale output, a change of 1 LSB in digital input code should result in a 2.44 mV change in the analog output ( \(1 \mathrm{LSB}=10 \mathrm{~V} \times 1 / 4096=2.44 \mathrm{mV}\) ). If in actual use, however, a 1LSB change in the input code results in a change of only 0.61 mV ( \(1 / 4 \mathrm{LSB}\) ) in analog output, the differential linearity error would be -1.83 mV , or \(-3 / 4 \mathrm{LSB}\). The AD667K and B grades have a max differential linearity error of \(1 / 2\) LSB, which specifies that every step will be at least \(1 / 2\) LSB and at most \(11 / 2\) LSB.

ORDERING GUIDE
\begin{tabular}{l|l|l|l|l}
\hline & \begin{tabular}{l} 
Temperature \\
Range \(-{ }^{\circ} \mathrm{C}\)
\end{tabular} & \begin{tabular}{l} 
Linearity \\
Error Max \\
@ \(25^{\circ} \mathrm{C}\)
\end{tabular} & \begin{tabular}{l} 
Gain T.C. \\
Max ppm \(/{ }^{\circ} \mathrm{C}\)
\end{tabular} & Package Option \({ }^{2}\) \\
\hline AD667JN & 0 to +70 & \(\pm 1 / 2 \mathrm{LSB}\) & 30 & PlasticDIP(N-28) \\
AD667JP & 0 to +70 & \(\pm 1 / 2 \mathrm{LSB}\) & 30 & PLCC(P-28A) \\
AD667KN & 0 to +70 & \(\pm 1 / 4 \mathrm{LSB}\) & 15 & Plastic DIP(N-28) \\
AD667KP & 0 to +70 & \(\pm 1 / 4 \mathrm{LSB}\) & 15 & PLCC(P-28A) \\
AD667AD & -25 to +85 & \(\pm 1 / 2 \mathrm{LSB}\) & 30 & Ceramic DIP(D-28) \\
AD667BD & -25 to +85 & \(\pm 1 / 4 \mathrm{LSB}\) & 15 & Ceramic DIP(D-28) \\
AD667SD & -55 to +125 & \(\pm 1 / 2 \mathrm{LSB}\) & 30 & Ceramic DIP(D-28) \\
AD667SE & -55 to +125 & \(\pm 1 / 2 \mathrm{LSB}\) & 30 & LCC(E-28A) \\
AD667/883B & -55 to +125 & \(\star\) & \(\star\) & \(\star\) \\
\hline
\end{tabular}

NOTES
*Refer to AD667/883B military data sheet.
\({ }^{1}\) For details on grade and package offerings screened in accordance with MIL-STD-883, refer to the Analog Devices Military Products Databook or current AD667/883B data sheet. \({ }^{2} \mathrm{D}=\) Ceramic DIP; \(\mathrm{E}=\) Leadless Ceramic Chip Carrier; \(\mathrm{N}=\) Plastic DIP; \(\mathrm{P}=\) Plastic Leaded Chip Carrier. For outline information see Package Information section.

\section*{FEATURES}

\author{
Ultrahigh Speed: Current Settling to 1 LSB in 90 ns for a Full-Scale Change in Digital Input. Voltage Settling to 1 LSB in 120 ns for a Full-Scale Change in Analog Input \\ 15 MHz Reference Bandwidth \\ Monotonicity Guaranteed over Temperature 10.24 mA Current Output or \(\mathbf{1 . 0 2 4}\) V Voltage Output Integral and Differential Linearity Guaranteed over Temperature \\ \(0.3^{\prime \prime}\) "Skinny DIP" Packaging \\ MIL-STD-883 Compliant Versions Available
}

\section*{PRODUCT DESCRIPTION}

The AD668 is an ultrahigh speed, 12 -bit, multiplying digital-toanalog converter, providing outstanding accuracy and speed performance in responding to both analog and digital inputs. The AD668 provides a level of performance and functionality in a monolithic device that exceeds that of many contemporary hybrid devices. The part is fabricated using Analog Devices' Complementary Bipolar (CB) Process, which features vertical NPN and PNP devices on the same chip without the use of dielectric isolation. The AD668's design capitalizes on this proprietary process in combination with standard low impedance circuit techniques to provide its unique combination of speed and accuracy in a monolithic part.
The wideband reference input is buffered by a high gain, closed loop reference amplifier. The reference input is essentially a 1 V , high impedance input, but trimmed resistive dividers are provided to readily accommodate 5 V and 1.25 V references. The reference amplifier features an effective small signal bandwidth of 15 MHz and an effective slew rate of \(3 \%\) of full scale/ns.
Multiple matched current sources and thin film ladder techniques are combined to produce bit weighting. The output range can nominally be taken as a 10.24 mA current output or a 1.024 V voltage output. Varying the analog input can provide modulation of the DAC full scale from \(10 \%\) to \(120 \%\) of its nominal value. Bipolar outputs can be realized through pin-strapping to provide two-quadrant operation without additional external circuitry.
Laser wafer trimming insures full 12 -bit linearity and excellent gain accuracy. All grades of the AD668 are guaranteed monotonic over their full operating temperature range. Furthermore, the output resistance of the DAC is trimmed to \(100 \Omega \pm 1.0 \%\).

FUNCTIONAL BLOCK DIAGRAM


The AD668 is available in four performance grades. The AD668JQ and KQ are specified for operation from \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\), the AD668AQ is specified for operation from \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\), and the AD668SQ specified for operation from \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\). All grades are available in a 24 -pin cerdip \(\left(0.3^{\prime \prime}\right.\) package.

\section*{PRODUCT HIGHLIGHTS}
1. The fast settling time of the AD668 provides suitable performance for waveform generation, graphics display, and highspeed A/D conversion applications.
2. The high bandwidth reference channel allows high frequency modulation between analog and digital inputs.
3. The AD668's design is configured to allow wide variation of the analog input, from \(10 \%\) to \(120 \%\) of its nominal value.
4. The AD668's combination of high performance and tremendous flexibility makes it an ideal building block for a variety of high speed, high accuracy instrumentation applications.
5. The digital inputs are readily compatible with both TTL and 5V CMOS logic families.
6. Skinny DIP ( \(0.3^{\prime \prime}\) ) packaging minimizes board space requirements and eases layout considerations.
7. The AD668 is available in versions compliant with MIL-STD-883. Refer to the Analog Devices Military Products Databook or current AD668/883B data sheet for detailed specifications.

\footnotetext{
This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.
}

AD668 - SDEGFFGATNNS ( \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=+15 \mathrm{~V}, \mathrm{~V}_{E E}=-15 \mathrm{~V}\), unless otherwise noted)

\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|}
\hline & \multicolumn{3}{|c|}{AD668J/A} & \multicolumn{3}{|c|}{AD668K} & \multicolumn{3}{|c|}{AD668S} & \\
\hline Parameter & Min & Typ & Max & Min & Typ & Max & Min & Typ & Max & Units \\
\hline \multicolumn{11}{|l|}{AC CHARACTERISTICS} \\
\hline \multicolumn{11}{|l|}{\multirow[t]{2}{*}{Analog Settling Time ( \(10 \%\) to \(120 \%\) Step)}} \\
\hline & & & & & & & & & & \\
\hline to \(\pm 1 \%\) & & 60 & & & * & & & * & & ns to \(1 \%\) of FSR \\
\hline to \(\pm 0.1 \%\) & & 90 & & & * & & & * & & ns to \(0.1 \%\) of FSR \\
\hline to \(\pm 0.025 \%\) & & 120 & & & * & & & \(\star\) & & ns to \(0.025 \%\) of FSR \\
\hline \multicolumn{11}{|l|}{Digital Settling Time} \\
\hline \multicolumn{11}{|l|}{Current} \\
\hline to \(\pm 1 \%\) & & 30 & & & * & & & * & & ns to \(1 \%\) of FSR \\
\hline to \(\pm 0.025 \%\) & & 90 & & & * & & & * & & ns to \(0.025 \%\) of FSR \\
\hline \multicolumn{11}{|l|}{Voltage (100 \(\Omega\), Internal \(\left.\mathrm{R}_{\mathrm{L}}\right)^{3}\)} \\
\hline to \(1 \%\) & & 50 & & & * & & & * & & ns to \(1 \%\) of FSR \\
\hline to \(0.1 \%\) & & 75 & & & * & & & \(\star\) & & ns to \(0.1 \%\) of FSR \\
\hline to 0.025\% & & 110 & & & * & & & * & & ns to \(0.025 \%\) of FSR \\
\hline Glitch Impulse \({ }^{4}\) & & 350 & & & * & & & * & & pV -sec \\
\hline Peak Amplitude & & 20 & & & * & & & * & & \% of FSR \\
\hline Total Harmonic Distortion \({ }^{5}\) & & -75 & & & * & & & * & & \\
\hline Multiplying Feedthrough Error \({ }^{6}\) & & -62 & & & * & & & * & & dB \\
\hline FULL-SCALE TRANSITION \({ }^{2}\) & & & & & & & & & & \\
\hline 10\% to 90\% Rise Time & & 11 & & & * & & & * & & ns \\
\hline 90\% to 10\% Fall Time & & 11 & & & * & & & * & & ns \\
\hline POWER REQUIREMENTS & & & & & & & & & & \\
\hline +10.8 V to +16.5 V & & 27 & 32 & & & * & & & * & mA \\
\hline -10.8 V to -16.5 V & & & 9 & & & * & & & \(\star\) & -mA \\
\hline Power Dissipation & & 510 & 615 & & & * & & & * & mW \\
\hline PSRR \({ }^{7}\) & & & 0.05 & & & * & & & * & \% of FSR/V \\
\hline TEMPERATURE RANGE & & & & & & & & & & \\
\hline Rated Specification \({ }^{2}\) (J, K, S) & 0 & & +70 & * & & * & -55 & & +125 & \({ }^{\circ} \mathrm{C}\) \\
\hline Rated Specification (A) & -40 & & +85 & & & & & & & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage & -65 & & +150 & * & & * & * & & * & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

\section*{NOTES}
*Same as AD668J/A.
\({ }^{1}\) Measured in \(\mathrm{I}_{\mathrm{OUT}}\) mode. Specified at nominal 5 V full-scale reference.
\({ }^{2}\) Measured in \(\mathrm{V}_{\text {Out }}\) mode, unless otherwise specified. Specified at nominal 5 V full-scale reference.
\({ }^{3}\) Total resistance.
\({ }^{4}\) At the major carry, driven by HCMOS logic.
\({ }^{5} \mathrm{~V}_{\text {OUT }}=1 \mathrm{~V} \mathrm{p}-\mathrm{p}, \mathrm{V}_{\text {IN }}=10 \%\) to \(110 \%, 100 \mathrm{kHz}\). Digital Input All 1s.
\({ }^{6} \mathrm{~V}_{\text {IN }}=200 \mathrm{mV}\) p-p, 1 MHz Sine Wave. Digital Input all 0 s .
\({ }^{7}\) Measured at \(15 \mathrm{~V} \pm 10 \%\) and \(12 \mathrm{~V} \pm 10 \%\).
Specifications shown in boldface are tested on all production units at final electrical test.
Specifications subject to change without notice.

\section*{ABSOLUTE MAXIMUM RATINGS*}
\begin{tabular}{|c|c|}
\hline \(\mathrm{V}_{\mathrm{CC}}\) to REFCOM & 0 V to +18 V \\
\hline \(\mathrm{V}_{\text {EE }}\) to REFCOM & 0 V to -18 V \\
\hline REFCOM to LCOM & +100 mV to -10 V \\
\hline ACOM to LCOM & \(\pm 100 \mathrm{mV}\) \\
\hline THCOM to LCOM & \(\pm 500 \mathrm{mV}\) \\
\hline REFCOM to REFIN (1, 2) & 18 V \\
\hline \(\mathrm{I}_{\text {BPO }}\) to LCOM & \(\pm 5 \mathrm{~V}\) \\
\hline \(\mathrm{I}_{\text {Out }}\) to LCOM & -5 V to \(\mathrm{V}_{\mathrm{TH}}\) \\
\hline Digital Inputs to THCOM & 500 mV to +7.0 V \\
\hline REFIN1 to REFIN2 & 36 V \\
\hline \(\mathrm{V}_{\text {TH }}\) to THCOM & -0.7 V to +1.4 V \\
\hline Logic Threshold Control In & 5 mA \\
\hline
\end{tabular}

Power Dissipation . . . . . . . . . . . . . . . . . . . . . . . . 670 mW Storage Temperature Range
Q (Cerdip) Package . . . . . . . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Junction Temperature . . . . . . . . . . . . . . . . . . . . . . \(+175^{\circ} \mathrm{C}\)
Thermal Resistance


\footnotetext{
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
}

ORDERING GUIDE
\begin{tabular}{l|l|l|l|l}
\hline & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Linearity \\
Error Max \\
@ \(25^{\circ} \mathrm{C}\)
\end{tabular} & \begin{tabular}{l} 
Voltage \\
Gain T.C. \\
Max ppm \(/{ }^{\circ} \mathrm{C}\)
\end{tabular} & \begin{tabular}{l} 
Package \\
Option \(^{2}\)
\end{tabular} \\
\hline AD668JQ & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 / 2\) & \(\pm 30\) & \(\mathrm{Q}-24\) \\
AD668KQ & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 / 4\) & \(\pm 15\) & \(\mathrm{Q}-24\) \\
AD668AQ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2\) & \(\pm 30\) & \(\mathrm{Q}-24\) \\
AD668SQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 / 2\) & \(\pm 40\) & \(\mathrm{Q}-24\) \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) For details on grade and package offerings screened in accordance with MIL-STD-883, refer to the Analog Devices Military Products Databook or current AD668/883B data sheet.
\({ }^{2} \mathrm{Q}=\) Cerdip. For outline information see Package Information section.

\section*{PIN CONFIGURATION}


\section*{DEFINITIONS}

LINEARITY ERROR (also called INTEGRAL NON-
LINEARITY OR INL): Analog Devices defines linearity error as the maximum deviation of the actual analog output from the ideal output (a straight line drawn from 0 to FS) for any bit combination expressed in multiples of 1 LSB. The AD668 is laser trimmed to \(1 / 4\) LSB ( \(0.006 \%\) of FS ) maximum linearity error at \(+25^{\circ} \mathrm{C}\) for the K version and \(1 / 2\) LSB for the J and S versions.
DIFFERENTIAL LINEARITY ERROR (also called DIFFERENTIAL NONLINEARITY or DNL): DNL is the measure of the variation in the analog output, normalized to full scale, associated with a 1 LSB change in digital input code.
MONOTONICITY: A DAC is said to be monotonic if the output either increases or remains constant as the digital input increases. Monotonic behavior requires that the differential linearity error not exceed 1 LSB in the negative direction.
UNIPOLAR OFFSET ERROR (DAC OFFSET): The DAC offset is the portion of the DAC output that is independent of the digital input. The unipolar DAC offset error is measured as the deviation of the analog output from the ideal ( 0 V or 0 mA ) when the analog input is set to \(100 \%\) and the digital inputs are set to all 0 s.

BIPOLAR OFFSET ERROR: The deviation of the analog output from the ideal (negative half-scale) when the DAC is connected in the bipolar mode (Pin 16 connected to Pin 20), the analog input is set to \(100 \%\), and the digital inputs are set to all 0 s is called the bipolar offset error.
BIPOLAR ZERO ERROR: The deviation of the analog output from the ideal ( 0 V or 0 mA ) for bipolar mode when only the MSB is on ( \(100 \ldots 00\) ) is called bipolar zero error.
COMPLIANCE VOLTAGE: The allowable voltage excursion at the output node of a DAC which will not degrade the accuracy of the DAC output.
SETTLING TIME (DIGITAL CHANNEL): The time required for the output to reach and remain within a specified error band about its final value, measured from the digital input transition.
SETTLING TIME (ANALOG CHANNEL): The time required for the output to reach and remain within a specified error band about its final value, measured from the analog input's crossing of it's \(50 \%\) value.
GAIN ERROR: The difference between the ideal and actual output span of FS-1 LSB, expressed either in \% of FS or LSB, when all bits are on is called the gain error.

\section*{FEATURES}

Complete 16-Bit D/A Function
On-Chip Output Amplifier
High Stability Buried Zener Reference
Monolithic BiMOS II Construction
\(\pm 1\) LSB Integral Linearity Error
15-Bit Monotonic over Temperature
Microprocessor Compatible
16-Bit Parallel Input
Double-Buffered Latches
Fast 40 ns Write Pulse
Unipolar or Bipolar Output
Low Glitch: 15 nV-s
Low THD+N: 0.009\%
MIL-STD-883 Compliant Versions Available

\section*{PRODUCT DESCRIPTION}

The AD669 DACPORT \({ }^{\text {® }}\) is a complete 16 -bit monolithic D/A converter with an on-board reference and output amplifier. It is manufactured on Analog Devices' BiMOS II process. This process allows the fabrication of low power CMOS logic functions on the same chip as high precision bipolar linear circuitry. The AD669 chip includes current switches, decoding logic, an output amplifier, a buried Zener reference and double-buffered latches.
The AD669's architecture insures 15 -bit monotonicity over temperature. Integral nonlinearity is maintained at \(\pm 0.003 \%\), while differential nonlinearity is \(\pm 0.003 \%\) max. The on-chip output amplifier provides a voltage output settling time of \(10 \mu\) s to within \(1 / 2\) LSB for a full-scale step.
Data is loaded into the AD669 in a parallel 16-bit format. The double-buffered latch structure eliminates data skew errors and provides for simultaneous updating of DACs in a multi-DAC system. Three TTL/LSTTL/5 V CMOS compatible signals control the latches: \(\overline{\mathrm{CS}}, \overline{\mathrm{L} 1}\) and LDAC.
The output range of the AD669 is pin programmable and can be set to provide a unipolar output range of 0 V to +10 V or a bipolar output range of -10 V to +10 V .

The AD669 is available in seven grades: AN and BN versions are specified from \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) and are packaged in a 28 -pin plastic DIP. The AR and BR versions are specified for \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) operation and are packaged in a 28 -pin SOIC. The SQ version is specified from \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) and is packaged in a hermetic 28 -pin cerdip package. The AD669 is also available compliant to MIL-STD-883. Refer to the AD669/883B data sheet for specifications and test conditions.
DACPORT is a registered trademark of Analog Devices, Inc.

\section*{FUNCTIONAL BLOCK DIAGRAM}


\section*{PRODUCT HIGHLIGHTS}
1. The AD669 is a complete voltage output 16 -bit DAC with voltage reference and digital latches on a single IC chip.
2. The internal buried Zener reference is laser trimmed to 10.000 volts with a \(\pm 0.2 \%\) maximum error. The reference voltage is also available for external applications.
3. The AD669 is both dc and ac specified. DC specs include \(\pm 1\) LSB INL error and \(\pm 1\) LSB DNL error. AC specs include \(0.009 \%\) THD +N and 83 dB SNR. The ac specifications make the AD669 suitable for signal generation applications.
4. The double-buffered latches on the AD669 eliminate data skew errors while allowing simultaneous updating of DACs in multi-DAC systems.
5. The output range is a pin-programmable unipolar 0 V to +10 V or bipolar -10 V to +10 V output. No external components are necessary to set the desired output range.
6. The AD669 is available in versions compliant with MIL-STD-883. Refer to the Analog Devices Military Products Databook or current AD669/883B data sheet for detailed specifications.

\section*{AD669}
-SPECFIFATIONS
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Model} & \multicolumn{3}{|c|}{AD669AN/AR} & \multicolumn{3}{|r|}{AD669AQ/SQ} & \multicolumn{3}{|l|}{AD669BN/BQ/BR} & \multirow[b]{2}{*}{Units} \\
\hline & Min & Typ & Max & Min & Typ & Max & Min & Typ & Max & \\
\hline RESOLUTION & 16 & & & 16 & & & 16 & & & Bits \\
\hline \[
\begin{aligned}
& \hline \text { DIGITAL INPUTS }\left(T_{M I N} \text { to } T_{M A X}\right) \\
& V_{I H} \text { (Logic " } 1 \text { ") } \\
& \mathrm{V}_{\mathrm{IL}}(\text { Logic " } 0 \text { ") } \\
& \mathrm{I}_{\mathrm{IH}}\left(\mathrm{~V}_{\mathrm{IH}}=5.5 \mathrm{~V}\right) \\
& \mathrm{I}_{\mathrm{IL}}\left(\mathrm{~V}_{\mathrm{IL}}=0 \mathrm{~V}\right)
\end{aligned}
\] & 2.0 & & \[
\begin{aligned}
& 5.5 \\
& 0.8 \\
& \pm 10 \\
& \pm 10
\end{aligned}
\] & * & & *
*
* & * & & *
*
* & \begin{tabular}{l}
Volts \\
Volts \(\mu \mathrm{A}\) \(\mu \mathrm{A}\)
\end{tabular} \\
\hline \begin{tabular}{l}
TRANSFER FUNCTION CHARACTERISTICS \({ }^{1}\) \\
Integral Nonlinearity \\
\(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) \\
Differential Nonlinearity \\
\(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) \\
Monotonicity Over Temperature \\
Gain Error \({ }^{2}\), 5 \\
Gain Drift \({ }^{2}\) ( \(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) ) \\
Unipolar Offset \\
Unipolar Offset Drift ( \(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) ) \\
Bipolar Zero Error \\
Bipolar Zero Error Drift ( \(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) )
\end{tabular} & 14 & & \[
\begin{aligned}
& \pm 2 \\
& \pm 4 \\
& \pm 2 \\
& \pm 4 \\
& \pm 0.15 \\
& 25 \\
& \pm 5 \\
& 5 \\
& \pm 15 \\
& 12
\end{aligned}
\] & 14 & & \begin{tabular}{l}
\[
\pm 0.10
\] \\
15 \\
\(\pm 5\) \\
3 \\
\(\pm 15\) \\
10
\end{tabular} & 15 & & \[
\begin{aligned}
& \pm 1 \\
& \pm 2 \\
& \pm 1 \\
& \pm 2 \\
& \pm 0.10 \\
& 15 \\
& \pm 2.5 \\
& \mathbf{3} \\
& \pm 10 \\
& 5
\end{aligned}
\] & \begin{tabular}{l}
LSB \\
LSB \\
LSB \\
LSB \\
Bits \\
\% of FSR \\
ppm \(/{ }^{\circ} \mathrm{C}\) \\
mV \\
ppm \(/{ }^{\circ} \mathrm{C}\) \\
mV \\
ppm \(/{ }^{\circ} \mathrm{C}\)
\end{tabular} \\
\hline \begin{tabular}{l}
REFERENCE INPUT \\
Input Resistance Bipolar Offset Input Resistance
\end{tabular} & & \[
\begin{aligned}
& 10 \\
& 10
\end{aligned}
\] & \[
\begin{aligned}
& 13 \\
& 13
\end{aligned}
\] & & * & * & & & * & \[
\begin{aligned}
& \mathbf{k} \Omega \\
& \mathbf{k} \Omega
\end{aligned}
\] \\
\hline \begin{tabular}{l}
REFERENCE OUTPUT \\
Voltage \\
Drift \\
External Current \({ }^{3}\) \\
Capacitive Load \\
Short Circuit Current
\end{tabular} & \[
\begin{aligned}
& 9.98 \\
& 2
\end{aligned}
\] & \[
\begin{aligned}
& 10.00 \\
& 4 \\
& 25
\end{aligned}
\] & \[
\begin{aligned}
& 10.02 \\
& 25 \\
& 1000
\end{aligned}
\] & & * & \(\stackrel{\text { * }}{15}\) & &  & \[
15
\] & \begin{tabular}{l}
Volts \\
ppm/ \({ }^{\circ} \mathrm{C}\) \\
mA \\
pF \\
mA
\end{tabular} \\
\hline \begin{tabular}{l}
OUTPUT CHARACTERISTICS \\
Output Voltage Range \\
Unipolar Configuration \\
Bipolar Configuration \\
Output Current \\
Capacitive Load \\
Short Circuit Current
\end{tabular} & \[
\begin{aligned}
& 0 \\
& 5 \\
& 5
\end{aligned}
\] & 25 & \[
\begin{aligned}
& +10 \\
& +10 \\
& 1000
\end{aligned}
\] & * & * & * & & * & * & \begin{tabular}{l}
Volts \\
Volts \\
mA \\
pF \\
mA
\end{tabular} \\
\hline  & \[
\begin{aligned}
& +13.5 \\
& -13.5 \\
& +4.5
\end{aligned}
\] & \[
\begin{aligned}
& +12 \\
& -12 \\
& 0.3 \\
& 3 \\
& 1 \\
& 365
\end{aligned}
\] & \[
\begin{aligned}
& +16.5 \\
& -16.5 \\
& +5.5 \\
& +18 \\
& -18 \\
& 2 \\
& 7.5 \\
& 3 \\
& 625
\end{aligned}
\] & * \({ }_{\text {* }}\) * & *
*
*
*
*
* & *
*
*
*
*
*
* & *
\(*\)
\(*\) & & *
\(\star\)
\(\star\)
\(\star\)
\(\star\)
\(\star\)
\(*\)
\(\star\)
\(\star\)
\(*\) & \begin{tabular}{l}
Volts \\
Volts \\
Volts \\
mA \\
mA \\
mA \\
mA \\
ppm/\% \\
mW
\end{tabular} \\
\hline TEMPERATURE RANGE Specified Performance (A, B) Specified Performance (S) & -40 & & +85 & \[
\begin{array}{r}
-40 \\
-55 \\
\hline
\end{array}
\] & & \[
\begin{aligned}
& +85 \\
& +125
\end{aligned}
\] & -40 & & +85 & \[
\begin{aligned}
& { }^{\circ} \mathrm{C} \\
& { }^{\circ} \mathrm{C} \\
& \hline
\end{aligned}
\] \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) For 16-bit resolution, \(1 \mathrm{LSB}=0.0015 \%\) of \(\mathrm{FSR}=15 \mathrm{ppm}\) of FSR. For 15 -bit resolution, \(1 \mathrm{LSB}=0.003 \%\) of \(\mathrm{FSR}=30 \mathrm{ppm}\) of FSR. For 14 -bit resolution

\({ }^{2}\) Gain error and gain drift measured using the internal reference. Gain drift is primarily reference related. See the Using the AD669 with the AD688 Reference section for further information.
\({ }^{3}\) External current is defined as the current available in addition to that supplied to REF IN and SPAN/BIPOLAR OFFSET on the AD669.
\({ }^{4}\) Operation on \(\pm 12 \mathrm{~V}\) supplies is possible using an external reference like the AD586 and reducing the output range. Refer to the Interna/External Reference Use section.
\({ }^{5}\) Measured with fixed \(50 \Omega\) resistors. Eliminating these resistors increases the gain error by \(0.25 \%\) of \(\operatorname{FSR}\) (Unipolar mode) or \(0.50 \%\) of FSR (Bipolar mode).
Refer to the Analog Circuit Connections section.
*Same as AD669AN/AR specification.
Specifications subject to change without notice.
Specifications in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed. Those shown in boldface are tested on all production units.

AC PERFORMANCE CHARACTERISTICS
(With the exception of Total Harmonic Distortion + Noise and Signal-to-Noise
Ratio, these characteristics are included for design guidance only and are not subject to test. THD \(+N\) and SNR are \(100 \%\) tested.
\(\mathrm{T}_{\text {MIN }} \leq \mathrm{T}_{\mathrm{A}} \leq \mathrm{T}_{\text {max }}, V_{\mathrm{CC}}=+15 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-15 \mathrm{~V}, \mathrm{~V}_{\mathrm{U}}=+5 \mathrm{~V}\) except where stated.)
\begin{tabular}{|c|c|c|c|}
\hline Parameter & Limit & Units & Test Conditions/Comments \\
\hline Output Settling Time (Time to \(\pm 0.0008 \%\) FS with \(2 \mathrm{k} \Omega, 1000 \mathrm{pF}\) Load) & \[
\begin{aligned}
& 13 \\
& 8 \\
& 10 \\
& 6 \\
& 8 \\
& 2.5
\end{aligned}
\] & Hs max \(\mu s\) typ \(\mu \mathrm{styp}\) \(\mu \mathrm{styp}\) \(\mu s\) typ \(\mu \mathrm{s}\) typ & \[
\begin{aligned}
& 20 \text { V Step, } \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\
& 20 \text { V Step, } \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\
& 20 \mathrm{~V} \text { Step, } \mathrm{T}_{\text {MIN }} \leq \mathrm{T}_{\mathrm{A}} \leq \mathrm{T}_{\text {MAX }} \\
& 10 \text { V Step, } \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\
& 10 \text { V Step } \mathrm{T}_{\text {MIN }} \leq \mathrm{T}_{\mathrm{A}} \leq \mathrm{T}_{\text {MAX }} \\
& 1 \text { LSB Step, } \mathrm{T}_{\text {MIN }} \leq \mathrm{T}_{\mathrm{A}} \leq \mathrm{T}_{\text {MAX }}
\end{aligned}
\] \\
\hline ```
Total Harmonic Distortion + Noise
    A, B, S Grade
    A, B, S Grade
    A, B, S Grade
``` & \[
\begin{aligned}
& 0.009 \\
& 0.07 \\
& 7.0
\end{aligned}
\] & \begin{tabular}{l}
\% max \\
\% max \\
\% max
\end{tabular} & \[
\begin{aligned}
& 0 \mathrm{~dB}, 1001 \mathrm{~Hz} \text {; Sample Rate }=100 \mathrm{kHz} ; \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\
& -20 \mathrm{~dB}, 1001 \mathrm{~Hz} ; \text { Sample Rate }=100 \mathrm{kHz} ; \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\
& -60 \mathrm{~dB}, 1001 \mathrm{~Hz} ; \text { Sample Rate }=100 \mathrm{kHz} ; \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}
\end{aligned}
\] \\
\hline Signal-to-Noise Ratio & 83 & dB min & \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) \\
\hline Digital-to-Analog Glitch Impulse & 15 & nV-s typ & DAC Alternately Loaded with 8000H and 7FFFH \\
\hline Digital Feedthrough & 2 & nV-s typ & DAC Alternately Loaded with 0000H and FFFFH; \(\overline{\text { CS }}\) High \\
\hline \[
\begin{aligned}
& \text { Output Noise Voltage } \\
& \text { Density }(1 \mathrm{kHz}-1 \mathrm{MHz})
\end{aligned}
\] & 120 & \(\mathrm{nV} / \sqrt{\mathrm{Hz}}\) typ & Measured at \(\mathrm{V}_{\text {OUT }}, 20 \mathrm{~V}\) Span; Excludes Reference \\
\hline Reference Noise & 125 & \(\mathrm{nV} / \sqrt{\text { Hz }}\) typ & Measured at REF OUT \\
\hline
\end{tabular}

Specifications subject to change without notice.
Specifications in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed. Those shown in boldface are tested on all production units.

TIMING CHARACTERISTICS
\(\mathbf{V}_{\mathrm{CC}}=+15 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-15 \mathrm{~V}, \mathbf{V}_{\mathrm{LI}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{HI}}=2.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{LO}}=0.4 \mathrm{~V}\)
\begin{tabular}{|c|c|c|c|c|}
\hline Parameter & \[
\begin{aligned}
& \text { Limit } \\
& +25^{\circ} \mathrm{C}
\end{aligned}
\] & \[
\begin{aligned}
& \text { Limit } \\
& -40^{\circ} \mathrm{C} \text { to } \\
& +85^{\circ} \mathrm{C}
\end{aligned}
\] & \[
\begin{aligned}
& \text { Limit } \\
& -55^{\circ} \mathrm{C} \text { to } \\
& +125^{\circ} \mathrm{C}
\end{aligned}
\] & Units \\
\hline \multicolumn{5}{|l|}{(Figure la)} \\
\hline \(\mathrm{t}_{\mathbf{C S}}\) & 40 & 50 & 55 & ns min \\
\hline \(\mathrm{t}_{\underline{L 1}}\) & 40 & 50 & 55 & ns min \\
\hline \(\mathrm{t}_{\mathrm{DS}}\) & 30 & 35 & 40 & ns min \\
\hline \(\mathrm{t}_{\mathrm{DH}}\) & 10 & 10 & 15 & ns min \\
\hline \(\mathrm{t}_{\mathbf{L H}}\) & 90 & 110 & 120 & ns min \\
\hline \(\mathrm{t}_{\text {LW }}\) & 40 & 45 & 45 & ns min \\
\hline \multicolumn{5}{|l|}{(Figure 1b)} \\
\hline \(\mathrm{t}_{\text {Low }}\) & 130 & 150 & 165 & ns min \\
\hline \(\mathrm{t}_{\text {HIGH }}\) & 40 & 45 & 45 & ns min \\
\hline \(\mathrm{t}_{\mathrm{DS}}\) & 120 & 140 & 150 & ns min \\
\hline \(\mathrm{t}_{\mathrm{DH}}\) & 10 & 10 & 15 & ns min \\
\hline
\end{tabular}

Specifications subject to change without notice.
Specifications in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed. Those shown in boldface are tested on all production units.


Figure 1a. AD669 Level Triggered Timing Diagram


TIE \(\overline{\mathbf{C S}}\) AND/OR \(\overline{\mathrm{L}}\) TO GROUND OR TOGETHER WITH LDAC
Figure 1b. AD669 Edge Triggered Timing Diagram

\section*{ESD SENSITIVITY}

The AD669 features input protection circuitry consisting of large transistors and polysilicon series resistors to dissipate both high-energy discharges (Human Body Model) and fast, low-energy pulses (Charged Device Model). Per Method 3015.2 of MIL-STD-883C, the AD669 has been classified as a Class 2 device.

Proper ESD precautions are strongly recommended to avoid functional damage or performance degradation. Charges as high as 4000 volts readily accumulate on the human body and test equipment and discharge without detection. Unused devices must be stored in conductive foam or shunts, and the foam should be discharged to the destination socket before devices are removed. For further information on ESD precautions, refer to Analog Devices' ESD Prevention Manual.


\section*{ABSOLUTE MAXIMUM RATINGS*}
\begin{tabular}{|c|c|}
\hline \multicolumn{2}{|l|}{\multirow[b]{14}{*}{}} \\
\hline & \\
\hline & \\
\hline & \\
\hline & \\
\hline & \\
\hline & \\
\hline & \\
\hline & \\
\hline & \\
\hline & \\
\hline & \\
\hline & \\
\hline & \\
\hline
\end{tabular}

PIN CONFIGURATION


ORDERING GUIDE
\begin{tabular}{|c|c|c|c|c|c|}
\hline Model & Temperature Range & Linearity Error Max \(\mathbf{T}_{\text {MIN }}-\mathbf{T}_{\text {MAX }}\) & Gain TC max ppm \(/{ }^{\circ} \mathrm{C}\) & Package Description & Package Option \({ }^{\text {* }}\) \\
\hline AD669AN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 4\) LSB & 25 & Plastic DIP & N-28 \\
\hline AD669AR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 4\) LSB & 25 & SOIC & R-28 \\
\hline AD669BN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 2\) LSB & 15 & Plastic DIP \({ }^{\prime}\) & N-28 \\
\hline AD669BR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 2\) LSB & 15 & SOIC & R-28 \\
\hline AD669SQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 4 \mathrm{LSB}\) & 15 & Cerdip & Q-28 \\
\hline AD669/883B** & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & ** & ** & ** & ** \\
\hline
\end{tabular}
\({ }^{\star} \mathrm{N}=\) Plastic DIP; Q = Cerdip; R = SOIC. For outline information see Package Information section. \(\star \star\) Refer to AD669/883B military data sheet.


THD+N vs. Temperature


THD+N vs. Frequency 16-Bit Self-Calibrating Seria/Byte DACPORT AD760

\author{
FEATURES \\ \(\pm 0.00076 \%\) Integral and Differential Linearity \(\pm 0.00038 \%\) Unipolar Offset, Bipolar Zero 17-Bit Monotonic \\ Complete 16-Bit D/A Function On-Chip Output Amplifier \\ On-Chip Buried Zener Voltage Reference \\ Microprocessor Compatible \\ Serial or Byte Input Double Buffered Latches Fast ( 40 ns ) Write Pulse Asynchronous Clear (to 0 V) Function \\ Serial Output Pin Facilitates Daisy Chaining \\ Pin Strappable Unipolar or Bipolar Output \\ Low Glitch: 15 nV-sec \\ Low THD+N: 0.009\% \\ Output Control on Power-Up \& Power-Down
}

\section*{PRODUCT DESCRIPTION}

The AD760 is a complete 16-bit self-calibrating monolithic DAC (DACPORT \({ }^{\circledR}\) ) with onboard voltage reference, double buffered latches and output amplifier. It is manufactured on Analog Devices' BiMOS II process. This process allows the fabrication of low power CMOS logic functions on the same chip as high precision bipolar linear circuitry.
Self-calibration is initiated by simply bringing the \(\overline{\mathrm{CAL}}\) pin low. The CALOK pin indicates when calibration has been successfully completed. The output multiplexer (MUX \({ }_{\text {OUT }}\) ) can be used to isolate the load from the movement of the DAC output during calibration. The INL and DNL errors are less than \(\pm 0.5\) LSB or \(\pm 0.00076 \%\) after calibration. Unipolar offset or bipolar zero is less than \(\pm 0.25\) LSB or \(\pm 0.00038 \%\). This level of performance is unmatched by any other monolithic DAC.

Data can be loaded into the AD760 in serial mode or as two 8 -bit bytes. This is made possible by two digital input pins which have dual functions (Pins 13 and 14). The serial mode input format is pin selectable, to be MSB or \(\overline{\mathrm{LSB}}\) first. In byte mode the user can similarly define whether the high byte or low byte is loaded first. The serial output ( \(\mathrm{S}_{\mathrm{OUT}}\) ) pin allows the user to daisy chain several AD760s by shifting the data through the input latch into the next DAC thus minimizing the number of control lines required in a multiple DAC application. The double buffered latch structure eliminates data skew errors and provides for simultaneous updating of DACs in a multi-DAC system.
The asynchronous \(\overline{\mathrm{CLR}}\) function can be configured to clear the output to unipolar or bipolar zero depending on the state of LBE (another dual-use pin) when CLR is strobed. The AD760

DACPORT is a registered trademark of Analog Devices, Inc.

FUNCTIONAL BLOCK DIAGRAM

also powers up or down with the output in a predetermined state by means of a digital and analog power supply detection circuit which is built in to the output multiplexer. This is particularly useful for robotic and industrial control applications.

The AD760 is available in three grades. AN and AP versions are specified from \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) and are packaged in a 28 -pin 600 mil plastic DIP and a 28 -pin PLCC. The SD version is packaged in a 28 -pin 600 mil cerdip package and is also available compliant to MIL-STD-883. Refer to the AD760/883B data sheet for specifications and test conditions.

\section*{PRODUCT HIGHLIGHTS}
1. Complete, true 16-bit, self-calibrating DAC, with a voltage reference, double-buffered latches and output amplifier on a single chip.
2. Pin programmable output can provide a unipolar output range of 0 V to +10 V or a bipolar output range of -10 V to +10 V . No external components required.
3. Asynchronous \(\overline{\text { CLR }}\) function can send the output to unipolar or bipolar zero.
4. \(\mathrm{MUX}_{\text {OUt }}\) is switched to a user defined input when powering up or down.
5. The AD760 is both dc and ac specified. DC specifications include \(\pm 0.5\) LSB INL and DNL errors. AC specifications include \(0.009 \%\) THD +N and 83 dB SNR.

This is a preliminary data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

AD760-SPEGEAMANNS \(\left(T_{A}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=+15 \mathrm{~V}, \mathrm{~V}_{E E}=-15 \mathrm{~V}, \mathrm{~V}_{\mathrm{LL}}=+5 \mathrm{~V}\right.\) unless otherwise stated)


This information applies to a product under development. Its characteristics and specifications are subject to change without notice.
Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

NOTES
\({ }^{1}\) For 16 -bit resolution, \(1 \mathrm{LSB}=0.0015 \%\) of FSR . For 15 -bit resolution, \(1 \mathrm{LSB}=0.003 \%\) of FSR . For 14-bit resolution, 1 LSB \(=0.006 \%\) of FSR . FSR stands for full-scale range and is 10 V in unipolar mode and 20 V in bipolar mode.
\({ }^{2}\) Characteristics are guaranteed at \(\mathrm{V}_{\text {our }}\) Pin (23).
\({ }^{3} \mathrm{~T}_{\mathrm{CAL}}\) is the calibration temperature.
\({ }^{4}\) Gain Error is measured with a fixed \(50 \Omega\) resistor as shown in Figure 4a and Figure 5a.
\({ }^{5}\) Gain Error and gain drift are measured with the internal reference. The internal reference is the main contributor to the gain drift. If lower drift is required the AD760 can be used with a precision external reference such as the AD587, AD586 or AD688.
\({ }^{6}\) DAC Gain Error is measured without the on-chip voltage reference. It represents the performance that can be obtained with an external precision reference.
\({ }^{7}\) External current is defined as the current available in addition to that supplied to REF IN and SPAN/BIPOLAR OFFSET on the AD760.
\({ }^{8}\) Operation on \(\pm 12 \mathrm{~V}\) supplies is possible using an external reference such as the AD586 and reducing the output range. Refer to the Internal/External Reference section.
*Indicates that the specification is the same as the AD760AN.
Specifications subject to change without notice.

\section*{AC PERFORMANCE CHARACTERISTICS with the exception of Total Harmonic Distortion + Noise and Signal-to-Noise} Ratio, these characteristics are included for design guidance only and are not subject to test. THD +N and \(\operatorname{SNR}\) are \(100 \%\) tested. ( \(\mathrm{T}_{\text {MIN }}<\mathrm{T}_{A}\) \(<\mathrm{T}_{\text {Max }}, \mathrm{V}_{\mathrm{CC}}=+15 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-15 \mathrm{~V}, \mathrm{~V}_{\mathrm{LL}}=+5 \mathrm{~V}\), tested at \(\mathrm{V}_{\text {OUT }}\) except where stated.)
\begin{tabular}{|c|c|c|c|}
\hline Parameter & Limit & Units & Test Conditions/Comments \\
\hline Output Settling Time (Time to \(+0.0008 \%\) FS, with \(2 \mathrm{k} \Omega, 1000 \mathrm{pF}\) Load) & \[
\begin{aligned}
& 13 \\
& 8 \\
& 10 \\
& 6 \\
& 8 \\
& 2.5
\end{aligned}
\] & \(\mu \mathrm{s}\) max \(\mu s\) typ \(\mu s\) typ \(\mu \mathrm{s}\) typ \(\mu s\) typ \(\mu \mathrm{styp}\) & \begin{tabular}{l}
20 V Step, \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) \\
20 V Step, \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) \\
20 V Step \\
10 V Step, \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) 10 V Step \\
1 LSB Step
\end{tabular} \\
\hline MUX \(_{\text {OUt }}\) Settling Time (Time to \(+0.0008 \%\) FS, with 100 pF Load) & \begin{tabular}{|c} 
\\
\\
TBD \\
TBD \\
TBD \\
TBD \\
TBD
\end{tabular} & un
\(\mu s \max\)
\(\mu s t y p\)
\(\mu s t y p\)
\(\mu s \operatorname{typ}\)
\(\mu s t y p\) & \begin{tabular}{l}
Settling Time is referenced to the rising edge of CALOK, when the multiplexer switches from \(\mathrm{MUX}_{\text {IN }}\) to \(\mathrm{V}_{\text {OUT }}\). \\
20 V Step, \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) \\
20 V Step, \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) \\
20 V Step \\
10 V Step, \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) \\
10 V Step
\end{tabular} \\
\hline \begin{tabular}{l}
Total Harmonic Distortion + Noise \\
A, S Grade \\
A, S Grade \\
A, S Grade
\end{tabular} & \[
\begin{aligned}
& 0.009 \\
& 0.07 \\
& 7.0 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
\% max \\
\% max \\
\% max
\end{tabular} & \[
\begin{aligned}
& 0 \mathrm{~dB}, 1001 \mathrm{~Hz} . \text { Sample Rate }=100 \mathrm{kHz} . \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\
& -20 \mathrm{~dB}, 1001 \mathrm{~Hz} . \text { Sample Rate }=100 \mathrm{kHz} . \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\
& -60 \mathrm{~dB}, 1001 \mathrm{~Hz} . \text { Sample Rate }=100 \mathrm{kHz} . \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}
\end{aligned}
\] \\
\hline Signal-to-Noise Ratio & 83 & dB min & \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) \\
\hline Digital-to-Analog Glitch Impulse & 15 & nV sec typ & DAC Alternatively Loaded with \(8000_{\mathrm{H}}\) and \(7 \mathrm{FFF}_{\mathrm{H}}\) \\
\hline MUX \({ }_{\text {OUT }}\) Glitch Impulse & TBD & nV sec typ & 100 pF Load \\
\hline Digital Feedthrough & 2 & nV sec typ & DAC Alternatively Loaded with \(0000_{\mathrm{H}}\) and \(\mathrm{FFFF}_{\mathrm{H}}\). \(\overline{\mathrm{CS}}\) High \\
\hline Output Noise Voltage Density ( \(1 \mathrm{kHz}-1 \mathrm{MHz}\) ) & 60 & \(\mathrm{nV} / \sqrt{\mathrm{Hz}}\) typ & Measured at \(\mathrm{V}_{\text {OUT }}\), 20 V Span, Excludes Reference \\
\hline Reference Noise ( \(1 \mathrm{kHz}-1 \mathrm{MHz}\) ) & 125 & \(\mathrm{nV} / \sqrt{\mathrm{Hz}}\) typ & Measured at REF OUT \\
\hline
\end{tabular}

\footnotetext{
Specifications are subject to change without notice.
}

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TIMING CHARACTERISTICS \(\left(v_{C C}=+15 v, v_{E E}=-15 \mathrm{~V}, \mathrm{v}_{\mathrm{L}}=+5 \mathrm{~V}, \mathrm{v}_{\mathrm{HI}}=2.4 \mathrm{~V}, \mathrm{v}_{\mathrm{LO}}=0.4 \mathrm{v}\right)\)


Specifications subject to change without notice.


Figure 1a. AD760 Byte Load Timing

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Figure 1b. AD760 Serial Load Timing


Figure 1c. Asynchronous Clear to Bipolar or Unipolar Zero


Figure 1d. Serial Out Timing


Figure 1e. Calibration Timing

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\section*{AD760}

\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD760 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

\section*{ABSOLUTE MAXIMUM RATINGS*}
\(\mathrm{V}_{\mathrm{CC}}\) to AGND . . . . . . . . . . . . . . . . . . . -0.3 V to +17.0 V
\(\mathrm{V}_{\mathrm{EE}}\) to AGND . . . . . . . . . . . . . . . . . . . +0.3 V to -17.0 V
\(\mathrm{V}_{\mathrm{LL}}\) to DGND . . . . . . . . . . . . . . . . . . . . -0.3 V to +7 V
AGND to DGND . . . . . . . . . . . . . . . . . . . . . . . . . . \(\pm 1\) V
Digital Inputs (Pins 2, 7-14, and 16-21)
to DGND . . . . . . . . . . . . . . . . . . . . . -1.0 V to +7.0 V
REF IN to AGND . . . . . . . . . . . . . . . . . . . . . . . \(\pm 10.5\) V
Span/Bipolar Offset to AGND . . . . . . . . . . . . . . . . \(\pm 10.5\) V
REF OUT, \(\mathrm{V}_{\text {OUT }}\), MUX \(_{\text {OUT }}\), MUX \(_{\text {IN }}\). . . . Indefinite Short to AGND, DGND, \(\mathrm{V}_{\mathrm{CC}}, \mathrm{V}_{\mathrm{EE}}\), and \(\mathrm{V}_{\mathrm{LL}}\)

Power Dissipation (Any Package)
To \(+60^{\circ} \mathrm{C}\). . . . . . . . . . . . . . . . . . . . . . . . . . . 1000 mW
Derates above \(+60^{\circ} \mathrm{C}\). . . . . . . . . . . . . . . . . . . \(8.7 \mathrm{~mW} /{ }^{\circ} \mathrm{C}\)
Storage Temperature . . . . . . . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Lead Temperature (Soldering, 10 sec ) . . . . . . . . . . . . . \(300^{\circ} \mathrm{C}\)
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ORDERING GUIDE
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline Model & Temperature Range & Linearity Error Max
\[
\mathrm{T}_{\mathrm{CAL}} \pm 20^{\circ} \mathrm{C}
\] & Unipolar Offset \(T_{\text {Cal }} \pm 20^{\circ} \mathrm{C}\) & Gain TC max ppm \(/{ }^{\circ} \mathrm{C}\) & Package Description & Package Option \({ }^{*}\) \\
\hline AD760AN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 0.5\) LSB & \(\pm 0.25 \mathrm{LSB}\) & 15 & Plastic DIP & N-28 \\
\hline AD760AP & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 0.5\) LSB & \(\pm 0.25 \mathrm{LSB}\) & 15 & PLCC & P-28A \\
\hline AD760SQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 0.5 \mathrm{LSB}\) & \(\pm 0.25 \mathrm{LSB}\) & 25 & Cerdip & Q-28 \\
\hline AD760SQ/883B** & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 0.5 \mathrm{LSB}\) & & ** & ** & ** \\
\hline
\end{tabular}

PIN CONFIGURATION


PLCC


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\section*{DEFINITIONS OF SPECIFICATIONS}

INTEGRAL NONLINEARITY: Analog Devices defines integral nonlinearity as the maximum deviation of the actual, adjusted DAC output from the ideal analog output (a straight line drawn from 0 to FS-1 LSB) for any bit combination. This is also referred to as relative accuracy.
DIFFERENTIAL NONLINEARITY: Differential nonlinearity is the measure of the change in the analog output, normalized to full scale, associated with a 1 LSB change in the digital input code. Monotonic behavior requires that the differential linearity error be greater than or equal to -1 LSB over the temperature range of interest.
MONOTONICITY: A DAC is monotonic if the output either increases or remains constant for increasing digital inputs with the result that the output will always be a single-valued function of the input.
GAIN ERROR: Gain error is a measure of the output error between an ideal DAC and the actual device output with all 1s loaded after offset error has been adjusted out.
OFFSET ERROR: Offset error is a combination of the offset errors of the voltage-mode DAC and the output amplifier and is measured with all 0 s loaded in the DAC.
BIPOLAR ZERO ERROR: When the AD760 is connected for bipolar output and \(10 \ldots 000\) is loaded in the DAC, the deviation of the analog output from the ideal midscale value of 0 V is called the bipolar zero error.
DRIFT: Drift is the change in a parameter (such as gain, offset and bipolar zero) over a specified temperature range, The drift temperature coefficient, specified in \(\mathrm{ppm} /{ }^{\circ} \mathrm{C}\), is calculated by . measuring the parameter at \(\mathrm{T}_{\text {MIN }}, 25^{\circ} \mathrm{C}\) and \(\mathrm{T}_{\text {MAX }}\) and dividing the change in the parameter by the corresponding temperature change.
TOTAL HARMONIC DISTORTION + NOISE: Total harmonic distortion + noise (THD +N ) is defined as the ratio of the square root of the sum of the squares of the values of the harmonics and noise to the value of the fundamental input frequency. It is usually expressed in percent (\%).
THD +N is a measure of the magnitude and distribution of linearity error, differential linearity error, quantization error and noise. The distribution of these errors may be different, depending upon the amplitude of the output signal. Therefore, to be the most useful, THD +N should be specified for both large and small signal amplitudes.
SIGNAL-TO-NOISE RATIO: The signal-to-noise ratio is defined as the ratio of the amplitude of the output when a fullscale signal is present to the output with no signal present. This is measured in dB .
DIGITAL-TO-ANALOG GLITCH IMPULSE: This is the amount of charge injected from the digital inputs to the analog output when the inputs change state. This is measured at half scale when the DAC switches around the MSB and as many as possible switches change state, i.e., from \(011 \ldots 111\) to 100 . . 000.
DIGITAL FEEDTHROUGH: When the DAC is not selected (i.e., \(\overline{\mathrm{CS}}\) is held high), high frequency logic activity on the digital inputs is capacitively coupled through the device to show up as noise on the \(V_{\text {OUt }}\) pin. This noise is digital feedthrough.

\section*{THEORY OF OPERATION}

The AD760 uses autocalibration circuitry to produce a true 16-bit DAC with less than 0.5 LSB Integral and Differential Linearity Error and 0.25 LSB Offset Error. The block diagram in Figure 2 shows the circuit components needed for calibration.
The MAIN DAC uses an array of bipolar current sources with MOS current steering switches to develop a current proportional to the applied digital word, ranging from 0 to 2 mA . A segmented architecture is used, where the most significant four data bits are thermometer decoded to drive 15 equal current sources. The lesser bits are scaled using a R-2R ladder, then applied together with the segmented sources at the summing node of the output amplifier. An extra LSB is added to the MAIN DAC, for use during calibration.

The self calibration architecture of the AD760 attempts to reduce the linearity errors of its transfer function. The algorithm measures and removes the carry errors (DNL errors) associated with the upper 64 codes, including the zero offset.
In normal operation the top six bits of a code entering the MAIN DAC simultaneously address the RAM, calling up a correction code which is then applied to the CALDAC. The output currents of both the MAIN DAC and CALDAC are combined in the summing amplifier to produce the corrected output voltage.

In the first step of calibration the output of the MAIN DAC is set to the code just below the code to be calibrated. The extra LSB in the MAIN DAC is turned on to find the extrapolated value for the next code. The comparator is then nulled using the TRANSFER STD DAC. The voltage at \(\mathrm{V}_{\text {OUT }}\) has in effect been sampled at the code to be calibrated.


Figure 2. Functional Block Diagram
Next, the extra LSB is turned off and the MAIN DAC code is incremented by one LSB. The comparator is once again nulled, this time with the CALDAC, until the \(\mathrm{V}_{\text {OUT }}\) is adjusted to equal the previously sampled output. The CALDAC code is stored in RAM and the process is repeated for the next code.

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Figure 3. INL Statistics
Calibration repeatability is limited by thermal noise and the finite resolution of the two adjusting DACs. Over many recalibrations the AD760 will produce less than 0.2 LSB of peak INL for \(90 \%\) of calibrations ( 0.5 LSB at a 30 ppm reject rate). A cumulative probability plot of the peak INL is shown in Figure 3.

\section*{ANALOG CIRCUIT CONNECTIONS}

Internal scaling resistors provided in the AD760 may be connected to produce a unipolar output range of 0 V to +10 V or a bipolar output range of -10 V to +10 V . Gain and offset drift are minimized in the AD760 because of the thermal tracking of the scaling resistors with other device components.

\section*{UNIPOLAR CONFIGURATION}

The configuration shown in Figure 4a will provide a unipolar 0 V to +10 V output range. In this mode a \(50 \Omega\) resistor is tied between REF OUT (Pin 26) and REF IN (Pin 25). It is possible to use the AD760 without any external components by tying Pin 26 directly to Pin 25 . Eliminating this resistor will increase the gain error by \(0.50 \%\) of FSR.


Figure 4a. 0 V to +10 V Unipolar Voltage Output
If it is desired to adjust the gain error to zero, this can be accomplished using the circuit shown in Figure 4b. The adjustment procedure is as follows:

STEP1 . . . ZERO ADJUST
Initiate calibration sequence. CALOK (Pin 1) must remain high throughout Gain Adjust.
STEP 2 . . . GAIN ADJUST
Turn all bits ON and adjust gain trimmer, R1, until the output is 9.999847 volts. (Full scale is adjusted to 1 LSB less than the nominal full scale of 10.000000 volts).


Figure \(4 b, 0 V\) to +10 V Unipolar Voltage Output with Gain Adjust

\section*{BIPOLAR CONFIGURATION}

The circuit shown in Figure 5a will provide a bipolar output voltage from -10.000000 V to +9.999694 V with positive full scale occurring with all bits ON. As in the unipolar mode, resistor R1 may be eliminated altogether to provide AD760 bipolar operation without any external components. Eliminating this resistor will increase the gain error by \(0.50 \%\) of FSR in the bipolar mode.


Figure 5a. \(\pm 10 \mathrm{~V}\) Bipolar Voltage \(\overline{\overline{\bar{O}} \text { utput }}\)

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Gain Error can be adjusted to zero using the circuit shown in Figure 5b.


Figure 5b. \(\pm 10\) V Bipolar Voltage Output Gain Adjustment

It should be noted that using external resistors will introduce a small temperature drift component beyond that inherent in the AD760. The internal resistors are trimmed to ratio-match and temperature-track other resistors on chip, even though their absolute tolerances are \(\pm 20 \%\) and absolute temperature coefficients are approximately \(-50 \mathrm{ppm} /{ }^{\circ} \mathrm{C}\). In the case that external resistors are used, the temperature coefficient mismatch between internal and external resistors, multiplied by the sensitivity of the circuit to variations in the external resistor value, will be the resultant additional temperature drift.

\section*{INTERNAL/EXTERNAL REFERENCE USE}

The AD760 has an internal low noise buried Zener diode reference which is trimmed for absolute accuracy and temperature coefficient. This reference is buffered and optimized for use in a high speed DAC and will give long-term stability equal or superior to the best discrete Zener diode references. The performance of the AD760 is specified with the internal reference driving the DAC and with the DAC alone (for use with a precision external reference).
The internal reference has sufficient buffering to drive external circuitry in addition to the reference currents required for the DAC (typically 1 mA to REF IN and 1 mA to BIPOLAR OFFSET). A minimum of 2 mA is available for driving external loads. The AD760 reference output should be buffered with an external op amp if it is required to supply more than 4 mA total current. The reference is tested and guaranteed to \(\pm 0.2 \% \max\) error.
It is also possible to use external references other than 10 volts with slightly degraded linearity specifications. The recommended range of reference voltages is +5 V to +10.24 V , which
allows \(5 \mathrm{~V}, 8.192 \mathrm{~V}\) and 10.24 V ranges to be used. For example, by using the AD586 5 V reference, outputs of 0 V to +5 V unipolar or \(\pm 5 \mathrm{~V}\) bipolar can be realized. Using the AD586 voltage reference makes it possible to operate the AD760 with \(\pm 12 \mathrm{~V}\) supplies with \(10 \%\) tolerances.
Figure 6 shows the AD760 using the AD586 precision 5 V reference in the bipolar configuration. The highest grade AD586MN is specified with a drift of \(2 \mathrm{ppm} /{ }^{\circ} \mathrm{C}\) which is a \(7.5 \times\) improvement over the AD760's internal reference. This circuit includes an optional potentiometer that can be used to adjust the gain error in a manner similar to that described in the BIPOLAR CONFIGURATION section. Use -5.000000 V and +4.999847 as the output values.
The AD760 can also be used with the AD587 10 V reference, using the same configuration shown in Figure 6 to produce a \(\pm 10 \mathrm{~V}\) output. The highest grade AD587LR, N is specified at \(5 \mathrm{ppm} /{ }^{\circ} \mathrm{C}\), which is a \(3 \times\) improvement over the AD760's internal reference.


Figure 6. Using the AD760 with the AD586 5 V Reference

\section*{OUTPUT SETTLING AND GLITCH}

The AD760's output buffer amplifier typically settles to within \(0.0008 \%\) FS ( \(1 / 2 \mathrm{LSB}\) ) of its final value in \(8 \mu \mathrm{~s}\) for a full-scale step. Figures 7a and 7b show settling for a full-scale and an LSB step, respectively, with a \(2 \mathrm{k} \Omega, 1000 \mathrm{pF}\) load applied. The guaranteed maximum settling time at \(+25^{\circ} \mathrm{C}\) for a full-scale step is \(13 \mu\) s with this load. The typical settling time for a 1 LSB step is \(2.5 \mu \mathrm{~s}\).
The digital-to-analog glitch impulse is specified as 15 nV -s typical. Figure 7c shows the typical glitch impulse characteristic at the code \(011 \ldots 111\) to \(100 \ldots 000\) transition when loading the second rank register from the first rank register.

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}


Figure 7. Output Characteristics

\section*{DIGITAL CIRCUIT DETAILS}

The AD760 has several "dual-use" pins which allow flexible operation while maintaining the lowest possible pin count and consequently the smallest package size. The following information is useful when applying the AD760.
The AD760 uses an internal Output Multiplexer to disconnect the DAC output from MUX OUT \(_{\text {(Pin 27) whe the device is }}\) uncalibrated or when a calibration sequence is in progress. At those times MUX \({ }_{\text {OUT }}\) is switched to MUX \({ }_{\text {IN }}\) (Pin 28) so the user can force a predetermined output voltage.
A Power On-Reset feature senses whenever any power supply is low enough to jeopardize the integrity of the calibration data in the RAM. At power-up or in the event of a power supply transient, CALOK (Pin 1) is low and the MUX OUt \(^{\text {pin }}\) is switched to \(\mathrm{MUX}_{\mathrm{IN}}\).

Self-Calibration is initiated by bringing the \(\overline{\mathrm{CAL}}\) pin low. The CALOK pin will go low and the MUX OUt pin is connected to MUX \(_{\text {IN }}\). After successful completion of calibration CALOK will go high and MUX \({ }_{\text {OUt }}\) is switched to \(\mathrm{V}_{\text {OUT }}\). The status of the calibration may be determined by taking the \(\overline{\mathrm{HBE}}\) pin low. CALOK either switches high if the calibration is in progress or CALOK remains low if a power supply voltage transient caused the AD760 to be set to the uncalibrated state.
Serial Mode Operation is enabled by bringing the \(\overline{\mathrm{SER}}\) (Pin 19) low. All unused data bits, DB2-DB7 must be tied low. This changes the function of DB0 (Pin 14) to that of the serial input pin, SIN. It also changes the function of DB1 (Pin 13) to a control input, MSB/ \(\overline{\mathrm{LSB}}\) that tells the AD760 which bit is going to be loaded first.
In serial mode the byte controls \(\overline{\mathrm{HBE}}\) (Pin 18) and \(\overline{\mathrm{LBE}}\) (Pin 17) are disabled, and Pin 17's function changes to control how the asynchronous clear function works: a low when \(\overline{\text { CLR }}\) is strobed sends the DAC to unipolar zero, a high sends it to bipolar zero.
Data is clocked into the input shift register on the rising edge of \(\overline{\mathrm{CS}}\) as shown in Figure 1b. The data is then resident in the first rank latch and can be loaded into the DAC by taking the LDAC pin high. This will cause the DAC to change to the appropriate output value. The second rank latch controlled by LDAC is a Transparent latch Changes in the first rank latch will be reflected in the DAC output immediately, as long as LDAC remains high.
It should be noted that the clear function clears the DAC latch but does not clear the first rank latch. Therefore, the data that was previously resident in the first rank latch can be reloaded by simply bringing LDAC high again. Alternatively, new data can be loaded into the first rank latch if desired.
The serial out pin ( \(\mathrm{S}_{\mathrm{OUT}}\) ) can be used to daisy chain several DACs together in multi-DAC applications to minimize the number of data lines required. The first rank latch simply acts like a 16-bit shift register, and repeated strobing of \(\overline{C S}\) will shift the data out through \(\mathrm{S}_{\text {OUT }}\) and into the next DAC. Each DAC in the chain will require its own LDAC signal unless all of the DACs are to be updated simultaneously.
Byte Mode Operation is enabled by setting \(\overline{\text { SER }}\) high, which configures DB0-DB7 as data inputs. In this mode \(\overline{\mathrm{HBE}}\) and \(\overline{\mathrm{LBE}}\) are used to identify the data as either the high byte or the low byte of the 16 -bit word. The user can load the data in either order into the first rank latch using the rising edge of the CS signal as shown in Figure la. The status of Pin 17, when CLR is strobed determines whether the AD760 clears to unipolar or bipolar zero. (But it can not be hardwired to the desired state, as in the serial mode.)
NOTE: \(\overline{\mathrm{CS}}\) and \(\overline{\mathrm{CAL}}\) are edge triggered. \(\overline{\mathrm{HBE}}, \overline{\mathrm{LBE}}, \overline{\mathrm{CLR}}\), \(\overline{\text { SER }}\), and LDAC are level triggered.

\section*{AD760 TO MC68HCīí (SPi BūS) İNTERFACE}

The AD760 interface to the Motorola SPI (serial peripheral interface) is shown in Figure 8. The MOSI, SCK, and \(\overline{\mathrm{SS}}\) pins of the HCll are respectively connected to the BIT0, \(\overline{\mathrm{CS}}\) and LDAC pins of the AD760. The SER pin of the AD760 is tied low causing the first rank latch to be transparent. The majority of the interfacing issues are taken care of in the software initialization. A typical routine such as the one shown below begins

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by initializing the state of the various SPI data and control registers.
The most significant data byte (MSBY) is then retrieved from memory and processed by the SENDAT subroutine. The \(\overline{S S}\) pin is driven low by indexing into the PORTD data register and clear Bit 5. This causes the 2nd rank latch of the AD760 to become transparent. The MSBY is then set to the SPI data register where it is automatically transferred to the AD760.
The HC11 generates the requisite 8 clock pulses with data valid on the rising edges. After the most significant byte is transmitted, the least significant byte (LSBY) is loaded from memory and transmitted in a similar fashion. To complete the transfer, the LDAC pin is driven high latching the complete 16 -bit word into the AD760.
\begin{tabular}{lll} 
INIT & LDAA \#\$2F & \(; \overline{\text { SS }}=1 ;\) SCK \(=0 ;\) MOSI \(=1\) \\
& STAA PORTD & ;SEND TO SPI OUTPUTS \\
& LDAA \#\$38 & ;SS, SCK,MOSI = OUTPUTS \\
& STAA DDRD & ;SEND DATA DIRECTION INFO \\
& LDAA \#\$50 & ;DABL INTRPTS,SPI IS MASTER \& ON \\
& STAA SPCR & ;CPOL \(=0\), CPHA \(=0,1 M H Z ~ B A U D ~ R A T E ~\) \\
NEXTPT LDAA MSBY & ;LOAD ACCUM W/UPPER 8 BITS \\
& BSR SENDAT & ;JUMP TO DAC OUTPUT ROUTINE \\
& JMP NEXTPT & ;INFINITE LOOP
\end{tabular}

SENDAT LDY \#\$1000 ;POINT AT ON-CHIP REGISTERS BCLR \$08,Y,\$20;DRIVE SS (LDAC) LOW STAA SPDR ;SEND MS-BYTE TO SPI DATA REG
WAIT1 LDAA SPSR ;CHECK STATUS OF SPIE
BPL WAIT1 ;POLL FOR END OF X-MISSION LDAA LSBY ;GET LOW 8 BITS FROM MEMORY STAA SPDR ;SEND LS-BYTE TO SPI DATA REG
WAIT2 LDAA SPSR ;CHECK STATUS OF SPIE BPL WAIT2 ;POLL FOR END OF X-MISSION BSET \(\$ 08, \mathrm{Y}, \$ 20\);DRIV \(\overline{\text { SS }}\) HIGH TO LATCH DATA RTS


Figure 8. AD760 to 68HC11 (SPI) Interface

\section*{AD760 TO MICROWIRE INTERFACE}

The flexible serial interface of the AD760 is also compatible with the National Semiconductor MICROWIRE^ interface. The MICROWIRE interface is used on microcontrollers such as the COP400 and COP800 series of processors. A generic interface to the MICROWIRE interface is shown in Figure 9. The G1, SK, and SO pins of the MICROWIRE interface are respectively connected to the LDAC, \(\overline{\mathrm{CS}}\) and BIT0 pins of the AD760.
*MICROWIRE is a registered trademark of National Semiconductor.


Figure 9. AD760 to MICROWIRE Interface

\section*{NOISE}

In high resolution systems, noise is often the limiting factor. A 16-bit DAC with a 10 volt span has an LSB size of \(153 \mu \mathrm{~V}\) ( -96 dB ). Therefore, the noise floor must remain below this level in the frequency range of interest. The AD760's noise spectral density is shown in Figures 10 and 11. Figure 12 shows the DAC output noise voltage spectral density for a 20 V span excluding the reference. This figure shows the \(1 / f\) corner frequency at 100 Hz and the wideband noise to be below \(120 \mathrm{nV} / \sqrt{\mathrm{Hz}}\). Figure 13 shows the reference noise voltage spectral density. This figure shows the reference wideband noise to be below \(125 \mathrm{nV} / \sqrt{\mathrm{Hz}}\).


Figure 10. DAC Output Noise Voltage Spectral Density


Figure 11. Reference Noise Voltage Spectral Density

\section*{BOARD LAYOUT}

Designing with high resolution data converters requires careful attention to board layout. Trace impedance is the first issue. A \(306 \mu \mathrm{~A}\) current through a \(0.5 \Omega\) trace will develop a voltage drop of \(153 \mu \mathrm{~V}\), which is 1 LSB at the 16 -bit level for a 10 V full-scale span. In addition to ground drops, inductive and capacitive coupling need to be considered, especially when high accuracy analog signals share the same board with digital signals. Finally, power supplies need to be decoupled in order to filter out ac noise.

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\section*{AD760}

Analog and digital signals should not share a common path. Each signal should have an appropriate analog or digital return routed close to it. Using this approach, signal loops enclose a small area, minimizing the inductive coupling of noise. Wide PC tracks, large gauge wire, and ground planes are highly recommended to provide low impedance signal paths. Separate analog and digital ground planes should also be used, with a single interconnection point to minimize ground loops. Analog signals should be routed as far as possible from digital signals and should cross them at right angles.
One feature that the AD760 incorporates to help the user layout is that the analog pins ( \(\mathrm{V}_{\mathrm{CC}}, \mathrm{V}_{\mathrm{EE}}\), REF OUT, REF IN, SPAN/ BIP OFFSET, \(V_{\text {OUT }}\), MUX \(_{\text {OUT }}\), MUX \(_{\text {IN }}\) and AGND) are adjacent to help isolate analog signals from digital signals.

\section*{SUPPLY DECOUPLING}

The AD760 power supplies should be well filtered, well regulated, and free from high frequency noise. Switching power supplies are not recommended due to their tendency to generate spikes which can induce noise in the analog system.
Decoupling capacitors should be used in very close layout proximity between all power supply pins and ground. A \(10 \mu \mathrm{~F}\) tantalum capacitor in parallel with a \(0.1 \mu \mathrm{~F}\) ceramic capacitor provides adequate decoupling. \(\mathrm{V}_{\mathrm{CC}}\) and \(\mathrm{V}_{\mathrm{EE}}\) should be bypassed to analog ground, while \(\mathrm{V}_{\mathrm{LL}}\) should be decoupled to digital ground.

An effort should be made to minimize the trace length between the capacitor leads and the respective converter power supply and common pins. The circuit layout should attempt to locate the AD760, associated analog circuitry and interconnections as far as possible from logic circuitry. A solid analog ground plane around the AD760 will isolate large switching ground currents. For these reasons, the use of wire wrap circuit construction is not recommended; careful printed circuit construction is preferred.

\section*{GROUNDING}

The AD760 has two pins, designated analog ground (AGND) and digital ground (DGND.) The analog ground pin is the "high quality" ground reference point for the device. Any external loads on the output of the AD760 should be returned to ana\(\log\) ground. If an external reference is used, this should also be returned to the analog ground.
If a single AD760 is used with separate analog and digital ground planes, connect the analog ground plane to AGND and the digital ground plane to DGND keeping lead lengths as short as possible. Then connect AGND and DGND together at the AD760. If multiple AD760s are used or the AD760 shares analog supplies with other components, connect the analog and digital returns together once at the power supplies rather than at each chip. This single interconnection of grounds prevents large ground loops and consequently prevents digital currents from flowing through the analog ground.

\section*{FEATURES}

\author{
Zero-Chip Interface to Digital Signal Processors Complete DACPORT \({ }^{\text {® }}\) \\ On-Chip Voltage Reference \\ Voltage and Current Outputs \\ Serial, Twos-Complement Input \\ \(\pm 3\) V Output \\ Sample Rates to 390 kSPS \\ 94 dB Minimum Signal-to-Noise Ratio \\ -81 dB Maximum Total Harmonic Distortion 15-Bit Monotonicity \(\pm 5 \mathrm{~V}\) to \(\pm 12 \mathrm{~V}\) Operation \\ 16-Pin Plastic and Ceramic Packages \\ Available in Commercial, Industrial, and Military Temperature Ranges
}

\section*{APPLICATIONS}

Digital Signal Processing
Noise Cancellation
Radar Jamming
Automatic Test Equipment
Precision Industrial Equipment
Waveform Generation

\section*{PRODUCT DESCRIPTION}

The AD766 16-bit DSP DACPORT provides a direct, threewire interface to the serial ports of popular DSP processors, including the ADSP-2101, TMS320CXX, and DSP56001. No additional "glue logic" is required. The AD766 is also complete, offering on-chip serial-to-parallel input format conversion, a 16-bit current-steering DAC, voltage reference, and a voltage output op amp. The AD766 is fabricated in Analog Devices' BiMOS II mixed-signal process which provides bipolar transistors, MOS transistors, and thin-film resistors for precision ana\(\log\) circuits in addition to CMOS devices for logic.
The design and layout of the AD766 have been optimized for ac performance and are responsible for its guaranteed and tested 94 dB signal-to-noise ratio to 20 kHz and 79 dB SNR to 250 kHz . Laser-trimming the AD766's silicon chromium thinfilm resistors reduces total harmonic distortion below -81 dB (at 1 kHz ), a specification also production tested. An optional linearity trim pin allows elimination of midscale differential linearity error for even lower THD with small signals.
The AD766's output amplifier provides a \(\pm 3 \mathrm{~V}\) signal with a high slew rate, small glitch, and fast settling. The output amplifier is short circuit protected and can withstand indefinite shorts to ground.

FUNCTIONAL BLOCK DIAGRAM


The serial interface consists of bit clock, data, and latch enable inputs. The twos-complement data word is clocked MSB first on falling clock edges into the serial-to-parallel converter, consistent with the serial protocols of popular DSP processors. The input clock can support data transfers up to 12.5 MHz . The falling edge of latch enable updates the internal DAC input register at the sample rate with the sixteen bits most recently clocked into the serial input register.
The AD766 operates over a \(\pm 5 \mathrm{~V}\) to \(\pm 12 \mathrm{~V}\) power supply range. The digital supplies, \(+\mathrm{V}_{\mathrm{L}}\) and \(-\mathrm{V}_{\mathrm{L}}\), can be separated from the analog signal supplies, \(+\mathrm{V}_{\mathrm{S}}\) and \(-\mathrm{V}_{\mathrm{S}}\), for reduced digital crosstalk. Separate analog and digital ground pins are also provided. An internal bandgap reference provides a precision voltage source to the output amp that is stable over temperature and time.
Power dissipation is typically 120 mW with \(\pm 5 \mathrm{~V}\) supplies and 300 mW with \(\pm 12 \mathrm{~V}\). The AD766 is available in commercial \(\left(0^{\circ} \mathrm{C}\right.\) to \(\left.70^{\circ} \mathrm{C}\right)\), industrial \(\left(-40^{\circ} \mathrm{C}\right.\) to \(\left.85^{\circ} \mathrm{C}\right)\), and military \(\left(-55^{\circ} \mathrm{C}\right.\) to \(125^{\circ} \mathrm{C}\) ) grades. Commercial and industrial grade parts are available in a 16 -pin plastic DIP; military parts processed to MIL-STD-883B are packaged in a 16 -pin ceramic DIP. See Analog Devices' Military Products Databook or current military data sheet for specifications for the military version.
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline Parameter & \multicolumn{2}{|l|}{\begin{tabular}{lc} 
Min & \(\left.\begin{array}{c}\text { AD766J } \\
\text { Typ }\end{array}\right]\)
\end{tabular}} & Max & \multicolumn{2}{|l|}{\begin{tabular}{cc} 
Min & AD766A \\
Typ
\end{tabular}} & Max & Units \\
\hline RESOLUTION & & & 16 & & & 16 & Bits \\
\hline \[
\begin{aligned}
& \hline \text { DIGITAL INPUTS } \\
& \mathrm{V}_{\mathrm{IH}} \\
& \mathrm{~V}_{\mathrm{IL}} \\
& \mathrm{I}_{\mathrm{IH}}, \mathrm{~V}_{\mathrm{IH}}=\mathrm{V}_{\mathrm{LL}} \\
& \mathrm{I}_{\mathrm{IL}}, \mathrm{~V}_{\mathrm{IL}}=0.4
\end{aligned}
\] & 2.0 & & \[
\begin{aligned}
& +V_{L} \\
& 0.8 \\
& 1.0 \\
& -10
\end{aligned}
\] & 2.0 & & \[
\begin{aligned}
& +V_{L} \\
& 0.8 \\
& 1.0 \\
& -10
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{~V} \\
& \mu \mathrm{~A} \\
& \mu \mathrm{~A}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
SERIAL PORT TIMING \\
Serial Clock Period ( \(\mathrm{t}_{\mathrm{cLK}}\) ) \\
Serial Clock HI ( \(\mathrm{t}_{\mathrm{HI}}\) ) \\
Serial Clock LO ( \(\mathrm{t}_{\mathrm{LO}}\) ) \\
Data Valid (t \(\mathrm{t}_{\text {ATA }}\) ) \\
Data Setup ( \(\mathrm{t}_{\mathrm{s}}\) ) \\
Data Hold ( \(\mathrm{t}_{\mathrm{H}}\) ) \\
Clock-to-Latch-Enable ( \(\mathrm{t}_{\text {ctie }}\) ) \\
Latch-Enable-to-Clock (t \(\mathrm{t}_{\text {LETC }}\) ) \\
Latch Enable HI ( \(\mathrm{t}_{\text {LehI }}\) ) \\
Latch Enable LO ( \(t_{\text {LeLo }}\) )
\end{tabular} & \[
\begin{aligned}
& 95 \\
& 30 \\
& 30 \\
& 40 \\
& 15 \\
& 15 \\
& 80 \\
& 15 \\
& 40 \\
& 40
\end{aligned}
\] & & & 115
30
70
40
20
20
100
15
40
80 & & & \begin{tabular}{l}
ns \\
ns \\
ns \\
ns \\
ns \\
ns \\
ns \\
ns \\
ns \\
ns
\end{tabular} \\
\hline \begin{tabular}{l}
ACCURACY \({ }^{1}\) \\
Gain Error \\
Gain Drift \\
Midscale Output Voltage Error \\
Bipolar Zero Drift \\
Differential Linearity Error \\
Monotonicity
\end{tabular} & & \[
\begin{aligned}
& \pm 2.0 \\
& \pm 25 \\
& \pm 30 \\
& \pm 4 \\
& \pm 0.001 \\
& 15
\end{aligned}
\] & & & \[
\begin{aligned}
& \pm 2.0 \\
& \pm 25 \\
& \pm 30 \\
& \pm 4 \\
& \pm 0.001 \\
& 15
\end{aligned}
\] & & \begin{tabular}{l}
\% of FSR \\
ppm of FSR \(/{ }^{\circ} \mathrm{C}\) \\
mV \\
ppm of FSR \(/{ }^{\circ} \mathrm{C}\) \\
\% of FSR \\
Bits.
\end{tabular} \\
\hline ```
TOTAL HARMONIC DISTORTION
    \(\mathrm{F}_{\text {OUT }}=1037 \mathrm{~Hz}^{1}\)
        0 dB
        \(-20 \mathrm{~dB}\)
        \(-60 \mathrm{~dB}\)
    \(\mathrm{F}_{\text {OUT }}=49.07 \mathrm{kHz}^{2}\)
        0 dB
        \(-20 \mathrm{~dB}\)
        \(-60 \mathrm{~dB}\)
``` & & \[
\begin{aligned}
& -88 \\
& -75 \\
& -37 \\
& -77 \\
& -69 \\
& -25
\end{aligned}
\] & \[
\begin{aligned}
& -81 \\
& -65 \\
& -27 \\
& -72 \\
& -66 \\
& -21
\end{aligned}
\] & & \[
\begin{aligned}
& -88 \\
& -75 \\
& -37 \\
& -77 \\
& -69 \\
& -25
\end{aligned}
\] & \[
\begin{aligned}
& -81 \\
& -65 \\
& -27 \\
& -72 \\
& -66 \\
& -21
\end{aligned}
\] & \begin{tabular}{l}
dB \\
dB \\
dB \\
dB \\
dB \\
dB
\end{tabular} \\
\hline \[
\begin{aligned}
& \text { SIGNAL-TO-NOISE RATIO }{ }^{3} \\
& 20 \mathrm{~Hz} \text { to } 20 \mathrm{kHz}\left(\mathrm{~F}_{\text {OUT }}=1037 \mathrm{~Hz}\right)^{1} \\
& 20 \mathrm{kHz} \text { to } 250 \mathrm{kHz}\left(\mathrm{~F}_{\text {OUT }}=49.07 \mathrm{kHz}\right)^{2}
\end{aligned}
\] & \[
\begin{aligned}
& 94 \\
& 79
\end{aligned}
\] & \[
\begin{aligned}
& 102 \\
& 83
\end{aligned}
\] & & \[
\begin{aligned}
& 94 \\
& 79
\end{aligned}
\] & \[
\begin{aligned}
& 102 \\
& 83
\end{aligned}
\] & & \[
\begin{aligned}
& \mathrm{dB} \\
& \mathrm{~dB}
\end{aligned}
\] \\
\hline ```
SETTLING TIME (to \(\pm 0.0015 \%\) of FSR)
    Voltage Output \({ }^{1}\)
        6 V Step
        1 LSB Step
        Slew Rate
    Current Output
        1 mA Step \(10 \Omega\) to \(100 \Omega\) Load
        \(1 \mathrm{k} \Omega\) Load
``` & & \[
\begin{aligned}
& 1.5 \\
& 1.0 \\
& 9 \\
& \\
& 350 \\
& 350
\end{aligned}
\] & & & \[
\begin{aligned}
& 1.5 \\
& 1.0 \\
& 9 \\
& 350 \\
& 350
\end{aligned}
\] & & \begin{tabular}{l}
\(\mu \mathrm{s}\) \(\mu \mathrm{s}\) V/us \\
ns \\
ns
\end{tabular} \\
\hline \begin{tabular}{l}
OUTPUT \\
Voltage Output Configuration \({ }^{1}\) Bipolar Range \\
Output Current \\
Output Impedance \\
Short Circuit Duration \\
Current Output Configuration Bipolar Range Output Impedance ( \(\pm 30 \%\) )
\end{tabular} & \(\pm 2.88\)

In
\(\pm 0.7\) & \begin{tabular}{l}
\[
\begin{aligned}
& \pm 3.0 \\
& \pm 8.0 \\
& 0.1
\end{aligned}
\] \\
nite to C
\[
\begin{aligned}
& \pm 1.0 \\
& 1.7
\end{aligned}
\]
\end{tabular} & \[
\pm 3.12
\]
\[
\pm 1.3
\] & \[
\begin{gathered}
\pm 2.88 \\
\pm 0.7
\end{gathered}
\] & \begin{tabular}{l}
\[
\begin{aligned}
& \pm 3.0 \\
& \pm 8.0 \\
& 0.1
\end{aligned}
\] \\
nite to C
\[
\pm 1.0
\]
\[
1.7
\]
\end{tabular} & \[
\pm 3.12
\]
\[
\pm 1.3
\] & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{~mA} \\
& \Omega \\
& \mathrm{~mA} \\
& \mathrm{k} \Omega
\end{aligned}
\] \\
\hline \[
\begin{aligned}
& \text { POWER SUPPLY } \\
& \text { Voltage: }+\mathrm{V}_{\mathrm{L}} \text { and }+\mathrm{V}_{\mathrm{S}} \\
& -\mathrm{V}_{\mathrm{L}} \text { and }-\mathrm{V}_{\mathrm{S}} \\
& \text { Current Case } 1^{1}: \mathrm{V}_{\mathrm{S}} \text { and } \mathrm{V}_{\mathrm{L}}=+5 \mathrm{~V} \\
& \quad-\mathrm{V}_{\mathrm{S}} \text { and }-\mathrm{V}_{\mathrm{L}}=-5 \mathrm{~V} \\
& \text { Case 2: } \\
& \mathrm{V}_{\mathrm{S}} \text { and } \mathrm{V}_{\mathrm{L}}=+12 \mathrm{~V} \\
& -\mathrm{V}_{\mathrm{S}} \text { and }-\mathrm{V}_{\mathrm{L}}=-12 \mathrm{~V} \\
& \text { Case 34: } \\
& \mathrm{V}_{\mathrm{S}} \text { and } \mathrm{V}_{\mathrm{L}}=+5 \mathrm{~V} \\
& -\mathrm{V}_{\mathrm{S}} \text { and }-\mathrm{V}_{\mathrm{L}}=-12 \mathrm{~V} \\
& \text { Power Dissipation: } \mathrm{V}_{\mathrm{S}} \text { and } \mathrm{V}_{\mathrm{L}}= \pm 5 \mathrm{~V}^{1} \\
& \mathrm{~V}_{\mathrm{S}} \text { and } \mathrm{V}_{\mathrm{L}}= \pm 12 \mathrm{~V} \\
& \mathrm{~V}_{\mathrm{S}} \text { and } \mathrm{V}_{\mathrm{L}}=+5 \mathrm{~V}, \\
& \\
& -\mathrm{V}_{\mathrm{S}} \text { and }-\mathrm{V}_{\mathrm{L}}=-12 \mathrm{~V}^{4} \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 4.75 \\
& -13.2
\end{aligned}
\] & \[
\begin{aligned}
& 12.0 \\
& -12.0 \\
& 10.5 \\
& -14 \\
& 12 \\
& -14 \\
& 120 \\
& 300 \\
& 225
\end{aligned}
\] & \[
\begin{aligned}
& 13.2 \\
& -4.75 \\
& 15.0 \\
& -15.0 \\
& \\
& 150
\end{aligned}
\] & \[
\begin{aligned}
& 4.75 \\
& -13.2
\end{aligned}
\] & \begin{tabular}{l}
\[
\begin{aligned}
& 12.0 \\
& -12.0 \\
& 10.5 \\
& -14 \\
& 12 \\
& -14 \\
& 120 \\
& 300
\end{aligned}
\] \\
225
\end{tabular} & \[
\begin{aligned}
& 13.2 \\
& -4.75 \\
& 15.0 \\
& -15.0 \\
& \\
& 150
\end{aligned}
\] & \begin{tabular}{l}
V \\
mA \\
mA \\
mA \\
mA \\
mA \\
mA \\
mW \\
mW \\
mW
\end{tabular} \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Parameter} & \multicolumn{3}{|c|}{AD766J} & \multicolumn{3}{|c|}{AD766A} & \multirow[b]{2}{*}{Units} \\
\hline & Min & Typ & Max & Min & Typ & Max & \\
\hline TEMPERATURE RANGE & & & & & & & \\
\hline Specified & 0 & & +70 & -40 & & +85 & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage & -60 & & +100 & -60 & & +100 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) For A grade only, voltage outputs are guaranteed only if \(+V_{s} \geq 7 \mathrm{~V}\) and \(-\mathrm{V}_{\mathrm{s}} \leq-7 \mathrm{~V}\).
\({ }^{2}\) Specified using external op amp, see Figure 3 for more details.
\({ }^{3}\) Tested at full-scale input.
\({ }^{4}\) For A grade only, power supplies must be symmetric, i.e., \(V_{S}=\left|-V_{S}\right|\) and \(+V_{L}=\left|-V_{L}\right|\). Each supply must independently meet this equality within \(\pm 5 \%\). All min and max specifications are guaranteed. Specifications in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels.
Specifications subject to change without notice.

\section*{ABSOLUTE MAXIMUM RATINGS*}

V \(_{\text {L }}\) to DGND . . . . . . . . . . . . . . . . . . . . . . . . . 0 to 13.2 V
\(\mathrm{V}_{\mathrm{S}}\) to AGND . . . . . . . . . . . . . . . . . . . . . . . . . 0 to 13.2 V
\(-V_{L}\) to DGND . . . . . . . . . . . . . . . . . . . . . -13.2 V to 0 V
\(-V_{\text {s }}\) to AGND . . . . . . . . . . . . . . . . . . . . -13.2 V to 0 V
Digital Inputs to DGND . . . . . . . . . . . . . . . . -0.3 V to \(\mathrm{V}_{\mathrm{L}}\)
AGND to DGND . . . . . . . . . . . . . . . . . . . . . . . . \(\pm 0.3\) V
Short Circuit Protection . . . . . . . . Indefinite Short to Ground
Soldering . . . . . . . . . . . . . . . . . . . . . . . . . \(+300^{\circ} \mathrm{C}\), 10 sec
*Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ORDERING GUIDE
\begin{tabular}{l|l|l}
\hline Model & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD766JN & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & \(\mathrm{N}-16\) \\
AD766AN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\mathrm{N}-16\) \\
AD766SD/883B & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\mathrm{D}-16\) \\
\hline
\end{tabular}
* \(N=\) Plastic DIP; D = Ceramic DIP. For outline information see Package Information section.
\begin{tabular}{l|l|l}
\multicolumn{2}{c}{ PIN DESIGNATIONS } \\
\hline Pin & Function & Description \\
\hline 1 & \(-V_{\text {S }}\) & Analog Negative Power Supply \\
2 & DGND & Digital Ground \\
3 & V \(_{\text {L }}\) & Logic Positive Power Supply \\
4 & NC & No Connection \\
5 & CLK & Clock Input \\
6 & LE & Latch Enable Input \\
7 & DATA & Serial Data Input \\
8 & - V \(_{\text {L }}\) & Logic Negative Power Supply \\
9 & V \(_{\text {OUT }}\) & Voltage Output \\
10 & R \(_{\text {F }}\) & Feedback Resistor \\
11 & SJ & Summing Junction \\
12 & AGND & Analog Ground \\
13 & IOUT & Current Output \\
14 & MSB ADJ & MSB Adjustment Terminal \\
15 & TRIM & MSB Trimming Potentiometer Terminal \\
16 & V \(_{\text {S }}\) & Analog Positive Power Supply \\
\hline
\end{tabular}

\section*{PIN DESIGNATIONS}

CONNECTION DIAGRAM


\section*{ESD SENSITIVITY}

The AD766 features input protection circuitry consisting of large "distributed" diodes and polysilicon series resistors to dissipate both high energy discharges (Human Body Model) and fast, low energy pulses (Charged Device Model). Per Method 3015.2 of MIL-STD-883C, the AD766 has been classified as a Category 1 Device.
Proper ESD precautions are strongly recommended to avoid functional damage or performance degradation. Charges as high as 4000 volts readily accumulate on the human body and test
 equipment, and discharge without detection. Unused devices must be stored in conductive foam or shunts, and the foam discharged to the destination socket before devices are removed. For further information on ESD precaution, refer to Analog Devices' ESD Prevention Manual.

\section*{FEATURES}

\author{
Complete 12-Bit D/A Function On-Chip Output Amplifier High Stability Buried Zener Reference \\ Fast 40ns Write Pulse \\ 0.3" Skinny DIP and PLCC Packages \\ Single Chip Construction \\ Monotonicity Guaranteed Over Temperature \\ Settling Time: \(3 \mu\) s max to \(1 / 2 L S B\) \\ Guaranteed for Operation with \(\pm 12 \mathrm{~V}\) or \(\pm 15 \mathrm{~V}\) \\ Supplies \\ TTL5V CMOS Compatible Logic Inputs \\ MIL-STD-883 Compliant Versions Available
}

\section*{PRODUCT DESCRIPTION}

The AD767 is a complete voltage output 12-bit digital-to-analog converter including a high stability buried Zener reference and input latch on a single chip. The converter uses 12 precision high-speed bipolar current steering switches and a laser-trimmed thin-film resistor network to provide high accuracy.
Microprocessor compatibility is achieved by the on-chip latch. The design of the input latch allows direct interface to 12 -bit buses. The latch responds to strobe pulses as short as 40 ns , allowing use with the fastest available microprocessors.

The functional completeness and high performance of the AD767 result from a combination of advanced switch design, high-speed bipolar manufacturing process, and the proven laser wafertrimming (LWT) technology.
The subsurface (buried) Zener diode on the chip provides a low-noise voltage reference which has long-term stability and temperature drift characteristics comparable to the best discrete reference diodes. The laser trimming process which provides the excellent linearity is also used to trim the absolute value of the reference as well as its temperature coefficient. The AD767 is thus well suited for wide temperature range performance with \(\pm 1 / 2\) LSB maximum linearity error and guaranteed monotonicity over the full temperature range. Typical full-scale gain T.C. is \(5 \mathrm{ppm} /{ }^{\circ} \mathrm{C}\).

\footnotetext{
\({ }^{*}\) Protected by Patent Numbers 3,803,590; 3,890,611; 3,932,863; 3,978,473 4,020,486; and others pending.
}

FUNCTIONAL BLOCK DIAGRAM


\section*{PRODUCT HIGHLIGHTS}
1. The AD767 is a complete voltage output DAC with voltage reference and digital latches on a single IC chip.
2. The input latch responds to write pulse widths as short as 40ns assuring direct interface with the industry's fastest microprocessors.
3. The internal buried Zener reference is laser-trimmed to \(\mathbf{1 0 . 0 0}\) volts with a \(\pm 1 \%\) maximum error. The reference voltage is also available for external application.
4. The gain setting and bipolar offset resistors are matched to the internal ladder network to guarantee a low gain temperature coefficient and are laser trimmed for minimum full-scale and bipolar offset errors.
5. The precision high-speed current steering switches and on-board high-speed output amplifier settle within 1/2LSB for a 10 V full-scale transition in \(3.0 \mu \mathrm{~s}\) when properly compensated.
6. The AD767 is available in versions compliant with MIL-STD883. Refer to the Analog Devices Military Products Databook or current AD767/883B data sheet for detailed specifications.

\[
T_{A}=T_{\min } \text { to } T_{\max }
\]
ential Linearity Error \(@+25^{\circ} \mathrm{C}\)
\(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\)

Unipolar Offset Error \({ }^{4}\)

GRIFT

\section*{NOTES}
'AD767 " S " specifications shown for information only. Consult Analog Devices Military Databook or contact factory for a controlled specification sheet.
\({ }^{2}\) AD767A Chips specifications are tested at \(+25^{\circ} \mathrm{C}\) and, when in boldface, at \(+85^{\circ} \mathrm{C}\). They are typical at \(-25^{\circ} \mathrm{C}\).
\({ }^{3}\) The digital input specifications are \(100 \%\) tested at \(+25^{\circ} \mathrm{C}\), and guaranteed but not tested over the full temperature range
\({ }^{4}\) Adjustable to zero.
\({ }^{5}\) FSR means "Full-Scale Range" and is 20 V for \(\pm 10 \mathrm{~V}\) range and 10 V for the \(\pm 5 \mathrm{~V}\) range.
\({ }^{6} \mathrm{~A}\) minimum power supply of \(\pm 12.5 \mathrm{~V}\) is required for a \(\pm 10 \mathrm{~V}\) full-scale output and \(\pm 11.4 \mathrm{~V}\) is required for all other voltage ranges.
Specifications subject to change without notice.
Specifications shown in boldface are tested on all production units at final electrical test (except per Notes 1 and 2). Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.

\section*{ABSOLUTE MAXIMUM RATINGS*}

VCC to Power Ground . . . . . . . . . . . . . . . 0 V to +18 V
\(\mathrm{V}_{\mathrm{EE}}\) to Power Ground . . . . . . . . . . . . . . . \(0 V\) to -18 V
Digital Inputs(Pins 11, 13-24)
to Power Ground . . . . . . . . . . . . . -1.0 V to +7.0 V
Ref In to Reference Ground . . . . . . . . . . . . . . . \(\pm 12 \mathrm{~V}\)
Bipolar Offset to Reference Ground . . . . . . . . . . . \(\pm 12 \mathrm{~V}\)
10V Span R to Reference Ground . . . . . . . . . . . . \(\pm 12 \mathrm{~V}\)
20V Span R to Reference Ground . . . . . . . . . . . . \(\pm 24 \mathrm{~V}\)

Ref Out, Vout (Pins 6, 9) . . Indefinite short to power ground Momentary Short to \(\mathrm{V}_{\mathrm{CC}}\)
Power Dissipation
1000 mW
* Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
\begin{tabular}{l|l|llll}
\hline Symbol & Parameter & Min & Typ & Max \\
\hline \(\mathrm{t}_{\text {DS }}\) & Data Valid to End of \(\overline{\mathrm{CS}}\) & 40 & - & - & ns \\
& \(\left(-25^{\circ} \mathrm{C}\right.\) to \(\left.+85^{\circ} \mathrm{C}\right)\) & 60 & - & - & ns \\
& \(\left(-55^{\circ} \mathrm{C}\right.\) to \(\left.+125^{\circ} \mathrm{C}\right)\) & 90 & - & - & ns \\
\hline \(\mathrm{t}_{\mathrm{DH}}\) & Data Hold Time & 10 & - & - & ns \\
& \(\left(-25^{\circ} \mathrm{C}\right.\) to \(\left.+85^{\circ} \mathrm{C}\right)\) & 10 & - & - & ns \\
& \(\left(-55^{\circ} \mathrm{C}\right.\) to \(\left.+125^{\circ} \mathrm{C}\right)\) & 20 & - & - & ns \\
\hline \(\mathrm{t}_{\mathrm{CS}}\) & \(\overline{\mathrm{CS}}\) Pulse Width & 40 & - & - & ns \\
& \(\left(-25^{\circ} \mathrm{C}\right.\) to \(\left.+85^{\circ} \mathrm{C}\right)\) & 60 & - & - & ns \\
& \(\left(-55^{\circ} \mathrm{C}\right.\) to \(\left.+125^{\circ} \mathrm{C}\right)\) & 90 & - & - & ns \\
\hline \(\mathrm{t}_{\text {SETT }}\) & Output Voltage Settling Time & - & 2 & 4 & \(\mu \mathrm{ss}\) \\
\hline
\end{tabular}
\({ }^{*} t_{\text {SETT }}\) is measured referenced to the leading edge of \(t_{C S}\). If \(t_{C S}>t_{D S}\), then \(t_{\text {SETT }}\) is measured referenced to the beginning of Data Valid.

PIN CONFIGURATION


ORDERING GUIDE
\begin{tabular}{|c|c|c|c|c|}
\hline Model \({ }^{1}\) & Package Option \({ }^{2}\) & Temperature Range \({ }^{\circ} \mathrm{C}\) & Linearity Error Max
\[
\mathbf{T}_{\min }-T_{\max }
\] & \begin{tabular}{l}
Gain T.C. \\
Max ppm \(/{ }^{\circ} \mathrm{C}\)
\end{tabular} \\
\hline AD767JN & Plastic DIP (N-24) & 0 to + 70 & \(\pm 1\) LSB & 30 \\
\hline AD767JP & PLCC(P-28A) & 0 to +70 & \(\pm 1 \mathrm{LSB}\) & 30 \\
\hline AD767KN & Plastic DIP (N-24) & 0 to +70 & \(\pm 1 / 2 \mathrm{LSB}\) & 15 \\
\hline AD767KP & PLCC(P-28A) & 0 to +70 & \(\pm 1 / 2 \mathrm{LSB}\) & 15 \\
\hline AD767AD & Ceramic DIP(D-24A) & -25 to +85 & \(\pm 1 \mathrm{LSB}\) & 30 \\
\hline AD767BD & Ceramic DIP (D-24A) & -25 to +85 & \(\pm 1 / 2 \mathrm{LSB}\) & 15 \\
\hline \[
\begin{aligned}
& \text { AD767SD/ } \\
& \text { 883B } \\
& \text { AD767A }
\end{aligned}
\] & Ceramic DIP(D-24A) & -55 to +125 & Note 2 & Note 2 \\
\hline Chips & N/A & -25 to +85 & \(\pm 1 \mathrm{LSB}\) & 30 \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1} \mathrm{D}=\) Ceramic DIP; \(\mathrm{N}=\) Plastic DIP; \(\mathbf{P}=\) Plastic Leaded Chip Carrier. For outline information see Package Information section.
\({ }^{2}\) For details on grade and package offerings screened in accordance with MIL-STD-883, refer to the Analog Devices Military Products Databook or current AD767/883B data sheet.

16-Bit, 32 MSPS Low Glitch D/A Converter

FEATURES
32 MSPS Update Rate
16-Bit Resolution
Linearity: 1 LSB DNL @ 14 Bits
1 LSB INL @ 14 Bits
Fast Settling: 25 ns Full-Scale Settling to 0.025\%
SFDR @ 1 MHz Output: 80 dBc
Low Glitch Impulse: \(\mathbf{6 0} \mathrm{pV}\)-s
Power Dissipation: 500 mW
On-Chip 2.5 V Reference
Edge-Triggered Latches
CMOS Compatibility

FUNCTIONAL BLOCK DIAGRAM


\section*{PRODUCT HIGHLIGHTS}
1. The low glitch and fast settling time provide outstanding dynamic performance for waveform reconstruction or digital synthesis requirements, including communications.
2. The excellent dc accuracy of the AD768 makes it suitable for high speed A/D conversion applications.
3. On-chip, edge-triggered input CMOS latches interface readily to CMOS logic families. The AD768 can support update rates up to 32 Msps .
4. A temperature compensated, 2.5 V bandgap reference is included on-chip allowing for generation of the reference input current with the use of a single external resistor. An external reference may also be used.
5. The current output(s) of the AD768 may be used singly or differentially, either into a load resistor or external op amp summing junction.
6. Proper selection of an external resistor and compensation capacitor allow the performance-conscious user to optimize the AD768 reference level and bandwidth for the target application.

This is a preliminary data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

\section*{PRODUCT DESCRIPTION}

The AD768 is a 16 -bit, high speed digital-to-analog converter (DAC) that offers exceptional ac and dc linearity. The AD768 is manufactured on Analog Devices' Advanced Bipolar CMOS (ABCMOS) process, combining the speed of bipolar transistors, the accuracy of laser trimmable thin-film resistors, and the efficiency of CMOS logic. A segmented current source architec- .a ture is combined with a proprietary switching technique to reduce glitch energy and maximize dynamic accuracy. Edge triggered input latches and a temperature compensated bandgap reference have been integrated to provide a complete monolithic DAC solution.
The AD768 is a current-output DAC with a nominal full-scale output current of 20 mA and a \(1 \mathrm{k} \Omega\) output impedance. Differential current outputs are provided to support single-ended or differential applications. The current outputs may be tied directly to an output resistor to provide a voltage output, or fed to the summing junction of a high speed amplifier to provide a buffered voltage output.
The on-chip reference and control amplifer are configured for maximum accuracy and flexibility. The AD768 can be driven by the on-chip reference or by a variety of external reference voltages based on the selection of an external resistor. An external capacitor allows the user to optimally tradeoff reference bandwidth and noise performance.
The AD768 operates on \(\pm 5 \mathrm{~V}\) supplies, typically consuming 500 mW of power. The AD768 is available in a 28 -pin SOIC package and is specified for operation over the industrial temperature range.

\begin{tabular}{l|lll|l}
\hline Parameter & Min & Typ & Max & Units \\
\hline RESOLUTION & 16 & & & Bits \\
\hline DC ACCURACY (16-Bit) \()^{1}\) & & & & \\
Linearity Error & -6 & \(\pm 4\) & +6 & LSB \\
\(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) & -8 & +8 & LSB \\
Differential Nonlinearity & -6 & \(\pm 4\) & +6 & LSB \\
\(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) & -8 & & +8 & LSB \\
\hline DC ACCURACY (14-Bit \()^{1,2}\) & & & \\
Linearity Error & \(-3 / 4\) & \(\pm 1 / 2\) & \(+3 / 4\) & LSB \\
\(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) & -1 & +1 & LSB \\
Differential Nonlinearity & \(-3 / 4\) & \(\pm 1 / 2\) & \(+3 / 4\) & LSB \\
\(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) & -1 & & +1 & LSB
\end{tabular}


This information applies to a product under development. Its characteristics and specifications are subject to change without notice.
Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.
\begin{tabular}{|c|c|c|c|c|}
\hline Parameter & Min & Typ & Max & Units \\
\hline \multicolumn{5}{|l|}{AC LINEARITY} \\
\hline \multicolumn{5}{|l|}{Spurious-Free Dynamic Range (SFDR)} \\
\hline \(\mathrm{f}_{\text {OUT }}=500 \mathrm{kHz}\); CLOCK \(=10 \mathrm{MHz}\) & & -80 & & dB \\
\hline \(\mathrm{f}_{\text {Out }}=1.0 \mathrm{MHz} ; \mathrm{CLOCK}=10 \mathrm{MHz}\) & & -80 & TBD & dB \\
\hline \(\mathrm{f}_{\text {OUT }}=5 \mathrm{MHz} ; \mathrm{CLOCK}=30 \mathrm{MHz}\) & & TBD & & dB \\
\hline \multicolumn{5}{|l|}{Total Harmonic Distortion (THD)} \\
\hline \(\mathrm{f}_{\text {OUT }}=500 \mathrm{kHz} ; \mathrm{CLOCK}=10 \mathrm{MHz}\) & & TBD & & dB \\
\hline \(\mathrm{f}_{\text {OUT }}=1.0 \mathrm{MHz} ; \mathrm{CLOCK}=10 \mathrm{MHz}\) & & TBD & TBD & dB \\
\hline \(\mathrm{f}_{\text {OUT }}=5 \mathrm{MHz} ; \mathrm{CLOCK}=30 \mathrm{MHz}\) & & TBD & & dB \\
\hline \multicolumn{5}{|l|}{POWER SUPPLY} \\
\hline Positive Voltage Range & 4.75 & & 5.25 & V \\
\hline Negative Voltage Range & -5.25 & & -4.75 & V \\
\hline Positive Supply Current & & 33 & TBD & mA \\
\hline Negative Supply Current & & 67 & TBD & mA \\
\hline Nominal Power Dissipation & & 500 & TBD & mW \\
\hline Power Supply Rejection Ratio (PSRR) & & & TBD & \% of FSR/V \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Measured at \(\mathrm{I}_{\text {OUT }} \mathrm{A}\), driving a virtual ground.
\({ }^{2}\) Three LSBs are grounded, DB0, DB1, and DB2.
\({ }^{3}\) Nominal FS output current is \(4 \times\) the current at IREFIN. Therefore, nominal FS current is 20 mA when IREFIN \(=5 \mathrm{~mA}\).
\({ }^{4}\) Output current is defined as total current available for IREFIN and any external load.
\({ }^{5}\) Reference bandwidth is a function of external cap at COMP pin.
\({ }^{6}\) Excludes internal reference drift.
\({ }^{7}\) Includes internal reference drift.
\({ }^{8}\) Measured as unbuffered voltage output ( 1 V step) with FS current into \(50 \Omega\) load
Specifications subject to change without notice.

ABSOLUTE MAXIMUM RATINGS \({ }^{1}\)
\begin{tabular}{|c|c|c|c|}
\hline Parameter & With Respect to & Min & Units \\
\hline Positive Supply Voltage ( \(\mathrm{V}_{\mathrm{DD}}\) ) & DCOM, REFCOM, LADCOM & \(-0.5+6.0\) & V \\
\hline Negative Supply Voltage ( \(\mathrm{V}_{\mathrm{EE}}\) ) & DCOM, REFCOM, LADCOM & \(-6.0+0.5\) & V \\
\hline Analog-to-Other Grounds (REFCOM) & DCOM, LADCOM & \(-0.5+0.5\) & V \\
\hline Digital-to-Other Grounds (DCOM) & LADCOM, REFCOM & \(-0.5+0.5\) & V \\
\hline Reference Output (REFOUT) & REFCOM & \(\mathrm{V}_{\mathrm{DD}}+0.5\) & V \\
\hline Reference Adjust (REFADJ) & REFCOM & \(-0.5 \quad \mathrm{~V}_{\mathrm{DD}}+0.5\) & V \\
\hline Reference Input Current (IREFIN) & & +6.0 & mA \\
\hline Digital Inputs (DB0-DB15, Clock) & DCOM & \(-0.5 \quad \mathrm{~V}_{\mathrm{DD}}+0.5\) & V \\
\hline Analog Outputs ( \(\mathrm{I}_{\text {OUT }} \mathrm{A}, \mathrm{I}_{\text {OUT }} \mathrm{B}\) ) & LADCOM & \(-2.0+5.0\) & V \\
\hline Maximum Junction Temperature & & +150 & \({ }^{\circ} \mathrm{C}\) \\
\hline Storage Temperature & & \(-65+150\) & \({ }^{\circ} \mathrm{C}\) \\
\hline Lead Temperature & & +300 & \({ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

\section*{NOTE}
\({ }^{1}\) Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating for extended periods may affect device reliability.

\section*{PIN CONFIGURATION}


\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD768 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


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\section*{PIN DESCRIPTION}
\begin{tabular}{l|l|l|l}
\hline Pin No. & Symbol & Type & Name and Function \\
\hline 1 & IOUTA & AO & DAC Current Output. Full-scale current when all data bits are 1s. \\
2 & COMP & AI & Compensation Node. Add capacitor for noise reduction. \\
3 & REFOUT & AO & Reference Output Voltage. Nominal value is 2.5 V. \\
4 & REFADJ & AI & Reference Adjust. Apply voltage from 0 to 2.5 V to adjust DAC gain. \\
5 & REFCOM & P & Reference Ground. \\
6 & IREFIN & AI & Reference Input Current. Nominal is 5 mA . DAC full-scale is \(4 \times\) this current. \\
7 & DB0 & DI & Data Bit 0 (LSB). \\
\(8-14\) & DB1-7 & DI & Data Bits 1-7. \\
15 & DCOM & P & Digital Ground. \\
16 & CLOCK & DI & Clock Input. Data latched on positive edge of clock. \\
\(17-23\) & DB8-DB14 & DI & Data Bits 8-14. \\
24 & DB15 & DI & Data Bit 15 (MSB). \\
25 & VDD & P & Positive Supply Voltage. Nominal is +5 V. \\
26 & VEE & P & Negative Supply Voltage. Nominal is -5 V. \\
27 & IOUTB & AO & Complementary DAC Current Output. Full-scale current when all data bits \\
& & & are 0s. \\
28 & LADCOM & P & DAC Ladder Common. \\
& & & \\
\hline
\end{tabular}

Type: \(\mathrm{AI}=\) Analog Input; \(\mathrm{DI}=\) Digital Input; \(\mathrm{AO}=\) Analog Output; \(\mathrm{P}=\) Power

ORDERING GUIDE
\begin{tabular}{l|l}
\hline Model & Package \\
\hline AD768AR & \(28-P i n ~ 300\) mil SOIC \\
\hline
\end{tabular}
*For outline information see Package Information section.

\section*{TIMING DIAGRAM}

DB0-DB15



Typical Configuration: Buffered Unipolar Voltage Output

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\section*{FEATURES}

Dynamic Range: \(\mathbf{8 8 . 5} \mathbf{~ d B}\)
Resolution: 0.375 dB
On-Chip Data Latches
+5 V Operation
AD7111A Pin Compatible with AD7524
Low Power
APPLICATIONS
Audio Attenuators
Sonar Systems
Function Generators
Digitally Controlled AGC System

\section*{GENERAL DESCRIPTION}

The LOGDAC \({ }^{\circledR}\) AD7111/AD7111A are monolithic multiplying D/A converters featuring wide dynamic range in a small package. Both DACs can attenuate an analog input signal over the range 0 dB to 88.5 dB in 0.375 dB steps. They are available in 16-pin DIPs and SOIC packages. The AD7111 is also available in a 20 -terminal LCCC package.
The degree of attenuation across the DAC is determined by an 8 -bit word applied to the on-board decode logic. This 8 -bit word is decoded into a 17 -bit word which is then applied to a 17 -bit R-2R ladder. The very fine step resolution, which is available over the entire dynamic range, is due to the use of this 17 -bit DAC.
The AD7111/AD7111A are easily interfaced to a standard 8-bit MPU bus via an 8 -bit data port and standard microprocessor control lines. The AD7111 \(\overline{\mathrm{WR}}\) input is edge triggered and requires a rising edge to load new data to the DAC. The AD7111A \(\overline{\mathrm{WR}}\) is level triggered to allow transparent operation of the latches, if required. It should also be noted that the AD7111A is exactly pin and function-compatible with the AD7524, an industry standard 8 -bit multiplying DAC. This allows an easy upgrading of existing AD7524 designs which would benefit both from the wider dynamic range and the finer step resolution offered by the AD7111A.
The AD7111/AD7111A are fabricated in Linear Compatible CMOS (LC \({ }^{2}\) MOS), an advanced, mixed technology process that combines precision bipolar circuits with low power CMOS logic.

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FUNCTIONAL BLOCK DIAGRAMS


\section*{PRODUCT HIGHLIGHTS}
1. Wide Dynamic Range: 0 dB to 88.5 dB attenuation range in 0.375 dB steps.
2. Small Package: The AD7111/AD7111A are available in 16-pin DIPs and SOIC packages.
3. Transparent Latch Operation: By tying the \(\overline{\mathrm{CS}}\) and \(\overline{\mathrm{WR}}\) inputs low, the DAC latches in the AD7111A can be made transparent.
4. Fast Microprocessor Interface: Data setup times of 25 ns and write pulse width of 57 ns make the AD7111A compatible with modern microprocessors.

\section*{AD7111/AD7111A-SPECIFICATIONS}

\begin{tabular}{|c|c|c|c|c|c|c|}
\hline Parameter & \multicolumn{2}{|l|}{AD7111L/C/U Grades
\[
\mathbf{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}, \mathrm{T}_{\mathrm{MAX}}
\]} & \multicolumn{2}{|l|}{AD7111K/B/T Grades
\[
\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \quad \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{MIN}}, \mathrm{~T}_{\mathrm{MAX}}
\]} & Units & Conditions/Comments \\
\hline NOMINAL RESOLUTION & 0.375 & 0.375 & 0.375 & 0.375 & dB & \\
\hline \begin{tabular}{l}
ACCURACY RELATIVE TO \\
0 dB ATTENUATION \\
0.375 dB Steps: \\
Accuracy \(\leqslant \pm 0.17 \mathrm{~dB}\) \\
Monotonic \\
0.75 dB Steps: \\
Accuracy \(\leqslant \pm 0.35 \mathrm{~dB}\) \\
Monotonic \\
1.5 dB Steps: \\
Accuracy \(\leqslant \pm 0.7 \mathrm{~dB}\) \\
Monotonic \\
3.0 dB Steps: \\
Accuracy \(\leqslant \pm 1.4 \mathrm{~dB}\) \\
Monotonic \\
6.0 dB Steps: \\
Accuracy \(\leqslant \pm 2.7 \mathrm{~dB}\) \\
Monotonic
\end{tabular} & \begin{tabular}{l}
\[
\begin{aligned}
& 0 \text { to } 36 \\
& 0 \text { to } 54
\end{aligned}
\] \\
0 to 48 \\
0 to 72 \\
0 to 54 \\
Full Range \\
0 to 66 \\
Full Range \\
0 to 72 \\
Full Range
\end{tabular} & \begin{tabular}{l}
0 to 36 \\
0 to 54 \\
0 to 42 \\
0 to 66 \\
0 to 48 \\
0 to 78 \\
0 to 54 \\
Full Range \\
0 to 60 \\
Full Range
\end{tabular} & \[
\begin{array}{|l}
0 \text { to } 30 \\
0 \text { to } 48 \\
0 \text { to } 42 \\
0 \text { to } 72 \\
\\
0 \text { to } 48 \\
0 \text { to } 85.5 \\
0 \text { to } 60 \\
\text { Full Range } \\
0 \text { to } 60 \\
\text { Full Range } \\
\hline
\end{array}
\] & \begin{tabular}{l}
0 to 30 \\
0 to 48 \\
0 to 36 \\
0 to 60 \\
0 to 42 \\
0 to 72 \\
0 to 48 \\
Full Range \\
0 to 48 \\
Full Range
\end{tabular} & \begin{tabular}{l}
dB min dB min \\
dB min dB min \\
dB min \\
\(\mathrm{dB} \min\) \\
dB min \\
dB min \\
dB min \\
dB min
\end{tabular} & \begin{tabular}{l}
Guaranteed Attenuation Ranges for Specified Step Sizes \\
Full Range Is from 0 dB to 88.5 dB
\end{tabular} \\
\hline GAIN ERROR & \(\pm 0.1\) & \(\pm 0.15\) & \(\pm 0.15\) & \(\pm 0.20\) & dB max & \\
\hline \(\mathrm{V}_{\text {IN }}\), INPUT RESISTANCE & 9/11/15 & 9/11/15 & 7/11/18 & 7/11/18 & \(\mathrm{k} \Omega\) min/typ/max & \\
\hline \(\mathrm{R}_{\text {FB }}\) INPUT RESISTANCE & 9.3/11.5/15.7 & 9.3/11.5/15.7 & 7.3/11.5/18.8 & 7.3/11.5/18.8 & \(\mathrm{k} \Omega\) min/typ/max & \\
\hline \begin{tabular}{l}
DIGITAL INPUTS \\
\(\mathrm{V}_{\mathrm{IH}}\) (Input High Voltage) \\
\(\mathrm{V}_{\mathrm{IL}}\) (Input Low Voltage) \\
Input Leakage Current
\end{tabular} & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 1
\end{aligned}
\] & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 10 \\
& \hline
\end{aligned}
\] & \[
\begin{array}{r}
2.4 \\
0.8 \\
\pm 1 \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 10 \\
& \hline
\end{aligned}
\] &  & Digital Inputs \(=\mathrm{V}_{\mathrm{DD}}\) \\
\hline ```
SWITCHING CHARACTERISTICS \({ }^{1}\)
    \(\mathrm{t}_{\mathrm{cs}}\)
    \(\mathrm{t}_{\mathrm{CH}}\)
    \(\mathrm{t}_{\mathrm{w} \cdot}\)
    \(t_{D S}\)
    \(\mathrm{t}_{\mathrm{DH}}\)
    \(\mathrm{t}_{\text {RFSH }}\)
``` & \[
\begin{array}{|l|}
\hline 0 \\
0 \\
350 \\
175 \\
10 \\
3 \\
\hline
\end{array}
\] & \begin{tabular}{l}
0
0 \\
500 \\
250 \\
10 \\
4.5
\end{tabular} & \[
\begin{array}{|l|}
\hline 0 \\
0 \\
350 \\
175 \\
10 \\
3 \\
\hline
\end{array}
\] & \begin{tabular}{l}
0
0 \\
500 \\
250 \\
10 \\
4.5
\end{tabular} & \begin{tabular}{l}
ns min \\
ns min \\
ns min \\
ns min \\
ns min \\
\(\mu \mathrm{s}\) min
\end{tabular} & \begin{tabular}{l}
Chip Select to Write Setup Time Chip Select to Write Hold Time Write Pulse Width \\
Data Valid to Write Setup Time Data Valid to Write Hold Time Refresh Time
\end{tabular} \\
\hline \begin{tabular}{l}
POWER SUPPLY \\
\(V_{D D}\) \\
\(I_{D D}\)
\end{tabular} & \[
\begin{aligned}
& +5 \\
& 1 \\
& 500
\end{aligned}
\] & \[
\begin{aligned}
& +5 \\
& 4 \\
& 1000
\end{aligned}
\] & \[
\left\lvert\, \begin{aligned}
& +5 \\
& 1 \\
& 500
\end{aligned}\right.
\] & \[
\begin{aligned}
& +5 \\
& 4 \\
& 1000
\end{aligned}
\] & V mA max \(\mu \mathrm{A}\) max & Digital Inputs \(=V_{I L}\) or \(V_{I H}\) Digital Inputs \(=0 \mathrm{~V}\) or \(\mathrm{V}_{\mathrm{DD}}\); See Figure 6 \\
\hline
\end{tabular}

NOTE
\({ }^{1}\) Sample tested at \(+25^{\circ} \mathrm{C}\) to ensure compliance.
Specifications subject to change without notice.
AC PERFORMANCE CHARACTERISTICS These characteristics are included for design guidance only and are not subject to test. \(\mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{IN}}=-10 \mathrm{~V}\) dc except where noted, \(\mathrm{I}_{\mathrm{OUT}}=A G N D=\mathrm{DGND}=0 \mathrm{~V}\), output amplifier AD711 except where noted.
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline Parameter & \multicolumn{2}{|l|}{AD7111L/C/U Grades
\[
\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}, \mathrm{T}_{\text {MAX }}
\]} & \[
\mathbf{T}_{\mathbf{A}}=
\] & \[
\begin{aligned}
& 1 \mathrm{~K} / \mathrm{B} / \mathrm{T} \\
& \mathrm{~T}_{\mathrm{A}}=
\end{aligned}
\] & Units & Conditions/Comments \\
\hline DC Supply Rejection, \(\Delta\) Gain \(/ \Delta \mathrm{V}_{\mathrm{DD}}\) & 0.001 & 0.005 & 0.001 & 0.005 & dB per \% max & \(\Delta V_{\text {DD }}= \pm 10 \%\), Input Code \(=00000000\) \\
\hline Propagation Delay & 3.0 & 4.5 & 3.0 & 4.5 & \(\mu s \max ^{\text {a }}\) & Full Scale Change Measured from \(\overline{\mathrm{WR}}\) Going High, \(\overline{\mathrm{CS}}=0 \mathrm{~V}\) \\
\hline Digital-to-Analog Glitch Impulse & 100 & - & 100 & - & nV secs typ & \begin{tabular}{l}
Measured with AD843 as Output \\
Amplifier for Code Transition \\
10000000 to 00000000 \\
Cl of Figure 1 is 0 pF
\end{tabular} \\
\hline Output Capacitance, Pin 1 & 185 & 185 & 185 & 185 & pF max & \\
\hline Input Capacitance, Pin 15 and Pin 16 & 7 & 7 & 7 & 7 & pF max & \\
\hline Feedthrough at 1 kHz & -94 & -72 & -92 & -68 & dB max & \\
\hline Total Harmonic Distortion & -91 & -91 & -91 & -91 & dB typ & \(\mathrm{V}_{\mathrm{IN}}=6 \mathrm{~V}\) rms at 1 kHz \\
\hline Output Noise Voltage Density & 70 & 70 & 70 & 70 & \(\mathrm{nV} / \sqrt{ } \mathrm{Hz}\) max & Includes AD711 Amplifier Noise \\
\hline Digital Input Capacitance & 7 & 7 & 7 & 7 & pF max & \\
\hline
\end{tabular}

\footnotetext{
Specifications subject to change without notice.
}

AD7111A-ELECTRICAL CHARACTERISTICS \(\left(V_{D D}=+5 \mathrm{~V}, \mathrm{~V}_{\mathbb{I N}}=-10 \mathrm{Vdc}, \mathrm{I}_{\mathrm{DUT}}=A G N D=D G N D=0 \mathrm{~V}\right.\) output amplifier AD711 except where noted)
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline Parameter & \multicolumn{2}{|l|}{AD7111AC Grade
\[
\mathbf{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \quad \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}, \mathrm{T}_{\text {MAX }}
\]} & \multicolumn{2}{|l|}{AD7111AB Grade
\[
\mathbf{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \quad \mathbf{T}_{\mathrm{A}}=\mathbf{T}_{\text {MIN }}, \mathbf{T}_{\text {MAX }}
\]} & Units & Conditions/Comments \\
\hline NOMINAL RESOLUTION & 0.375 & 0.375 & 0.375 & 0.375 & dB & \\
\hline \begin{tabular}{l}
ACCURACY RELATIVE TO 0 dB ATTENUATION \\
0.375 dB Steps: \\
Accuracy \(\leqslant \pm 0.17 \mathrm{~dB}\) \\
Monotonic \\
0.75 dB Steps: \\
Accuracy \(\leqslant \pm 0.35 \mathrm{~dB}\) \\
Monotonic \\
1.5 dB Steps: \\
Accuracy \(\leqslant \pm 0.7 \mathrm{~dB}\) \\
Monotonic \\
3.0 dB Steps: \\
Accuracy \(\leqslant \pm 1.4 \mathrm{~dB}\) \\
Monotonic \\
6.0 dB Steps: \\
Accuracy \(\leqslant \pm 2.7 \mathrm{~dB}\) \\
Monotonic
\end{tabular} & \begin{tabular}{l}
0 to 36 \\
0 to 54 \\
0 to 48 \\
0 to 72 \\
0 to 54 \\
Full Range \\
0 to 66 \\
Full Range \\
0 to 72 \\
Full Range
\end{tabular} & \begin{tabular}{l}
0 to 36 \\
0 to 54 \\
0 to 42 \\
0 to 66 \\
0 to 48 \\
0 to 78 \\
0 to 54 \\
Full Range \\
0 to 60 \\
Full Range
\end{tabular} & \begin{tabular}{l}
0 to 30 \\
0 to 48 \\
0 to 42 \\
0 to 72 \\
0 to 48 \\
0 to 85.5 \\
0 to 60 \\
Full Range \\
0 to 60 \\
Full Range
\end{tabular} & \begin{tabular}{l}
0 to 30 \\
0 to 48 \\
0 to 36 \\
0 to 60 \\
0 to 42 \\
0 to 72 \\
0 to 48 \\
Full Range \\
0 to 48 \\
Full Range
\end{tabular} & \begin{tabular}{l}
dB min dB min \\
dB min dB min \\
dB min \\
dB min \\
dB min \\
dB min \\
dB min dB min
\end{tabular} & \begin{tabular}{l}
Guaranteed Attenuation Ranges for Specified Step Sizes \\
Full Range Is from 0 dB to 88.5 dB
\end{tabular} \\
\hline GAIN ERROR & \(\pm 0.1\) & \(\pm 0.15\) & \(\pm 0.15\) & \(\pm 0.20\) & dB max & \\
\hline \(\mathrm{V}_{\text {IN }}\) INPUT RESISTANCE & 9/11/15 & 9/11/15 & 7/11/18 & 7/11/18 & \(\mathrm{k} \Omega\) min/typ/max & \\
\hline \(\mathrm{R}_{\text {FS }}\) INPUT RESISTANCE & 9.3/11.5/15.7 & 9.3/11.5/15.7 & 7.3/11.5/18.8 & 7.3/11.5/18.8 & \(\mathrm{k} \Omega\) min/typ/max & \\
\hline \begin{tabular}{l}
DIGITAL INPUTS \\
\(\mathrm{V}_{\mathrm{IH}}\) (Input High Voltage) \(\mathrm{V}_{\mathrm{IL}}\) (Input Low Voltage) Input Leakage Current
\end{tabular} & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm
\end{aligned}
\] & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 10
\end{aligned}
\] & \[
\begin{array}{|l}
2.4 \\
0.8 \\
\pm 1 \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 10 \\
& \hline
\end{aligned}
\] & \(V_{\text {min }}\) V max \(\mu \mathrm{A}\) max & Digital Inputs \(=\mathrm{V}_{\mathrm{DD}}\) \\
\hline \begin{tabular}{c}
\(\substack{\text { SWITCHING CHARACTERISTICS } \\
\mathrm{t}_{\mathrm{cs}} \\
\mathrm{t}_{\mathrm{CH}} \\
\mathrm{t}_{\mathrm{wR}} \\
\mathrm{t}_{\mathrm{DS}} \\
\mathrm{t}_{\mathrm{DH}} \\
\hline}\) \\
\hline
\end{tabular} & \[
\begin{array}{|l|}
\hline 0 \\
0 \\
57 \\
25 \\
10 \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 0 \\
& 0 \\
& 57 \\
& 25 \\
& 10 \\
& \hline
\end{aligned}
\] & \[
\begin{array}{|l|}
\hline 0 \\
0 \\
57 \\
25 \\
10 \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 0 \\
& 0 \\
& 57 \\
& 25 \\
& 10 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \text { ns min } \\
& \text { ns } \min \\
& \text { ns min } \\
& \text { ns min } \\
& \text { ns min }
\end{aligned}
\] & Chip Select to Write Setup Time Chip Select to Write Hold Time Write Pulse Width Data Valid to Write Setup Time Data Valid to Write Hold Time \\
\hline \[
\begin{aligned}
& \text { POWER SUPPLY } \\
& \mathrm{V}_{\mathrm{DD}} \\
& \mathrm{I}_{\mathrm{DD}}
\end{aligned}
\] & & \[
\begin{aligned}
& +5 \\
& 2 \\
& 1
\end{aligned}
\] & \[
\begin{aligned}
& +5 \\
& 1 \\
& 1
\end{aligned}
\] & \[
\begin{aligned}
& +5 \\
& 2
\end{aligned}
\] & V mA max mA max & \[
\begin{aligned}
& \text { Data Inputs }=\mathrm{V}_{\mathrm{IL}} \text { or } \mathrm{V}_{\mathrm{IH}} \\
& \overline{\mathrm{CS}}=\overline{\mathrm{WR}}=0 \mathrm{~V} \\
& \text { Digital Inputs }=0 \mathrm{~V} \text { or } \mathrm{V}_{\mathrm{DD}} ; \\
& \text { See Figure } 6
\end{aligned}
\] \\
\hline
\end{tabular}

NOTE
\({ }^{1}\) Sample tested at \(+25^{\circ} \mathrm{C}\) to ensure compliance.
Specifications subject to change without notice.

\section*{AC PERFORMANCE CHARACTERISTICS These characteristics are included for design guidance only and are not subject} to test. \(\mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathbb{I N}}=-10 \mathrm{~V}\) dc except where noted, \(\mathrm{I}_{\mathrm{OUT}}=\mathrm{AGND}=\mathrm{DGND}=0 \mathrm{~V}\), output amplifier AD711 except where noted.
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline Parameter & \multicolumn{2}{|l|}{AD7111AC Grade
\[
\mathbf{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}, \mathrm{T}_{\text {MAX }}
\]} & \[
\mathbf{T}_{\mathrm{A}}=
\] & 11AB Grade
\[
\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}, \mathrm{T}_{\text {MAX }}
\] & Units & Conditions/Comments \\
\hline DC Supply Rejection, \(\Delta\) Gain \(/ \Delta \mathrm{V}_{\mathrm{DD}}\) & 0.001 & 0.005 & 0.001 & 0.005 & dB per \% max & \(\Delta V_{\text {DD }}= \pm 10 \%\), Input Code \(=00000000\) \\
\hline Propagation Delay & 1 & 1.5 & & 1.5 & \(\mu \mathrm{s}\) max & Full Scale Change Measured from \(\overline{\mathrm{WR}}\) Going High, \(\overline{\mathrm{CS}}=0 \mathrm{~V}\) \\
\hline Digital-to-Analog Glitch Impulse & 10 & 20 & & 20 & nV secs typ & \begin{tabular}{l}
Measured with AD843 as Output \\
Amplifier for Code Transition \\
10000000 to 00000000 \\
Cl of Figure 1 is 0 pF
\end{tabular} \\
\hline Output Capacitance, Pin 1 & 50 & 50 & 50 & 50 & pF max & \\
\hline Input Capacitance, Pin 15 and Pin 16 & 7 & 7 & 7 & 7 & pF max & \\
\hline Feedthrough at 1 kHz & -94 & -90 & -92 & -90 & dB max & \\
\hline Total Harmonic Distortion & -91 & -91 & -91 & -91 & dB typ & \(\mathrm{V}_{\text {IN }}=6 \mathrm{~V}\) rms at 1 kHz \\
\hline Output Noise Voltage Density & 70 & 70 & 70 & 70 & \(\mathrm{nV} / \sqrt{ } \mathrm{Hz}\) max & Includes AD711 Amplifier Noise \\
\hline Digital Input Capacitance & 7 & 7 & 7 & 7 & pF max & \\
\hline
\end{tabular}

\footnotetext{
Specifications subject to change without notice.
}


ABSOLUTE MAXIMUM RATINGS*
\(\left(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right.\) unless otherwise noted)
\(\mathrm{V}_{\mathrm{DD}}\) (to DGND) . . . . . . . . . . . . . . . . . . . . . . . . . . +7 V
\(\mathrm{V}_{\mathrm{IN}}\) (to AGND) . . . . . . . . . . . . . . . . . . . . . . . . . . \(\pm 35 \mathrm{~V}\)
Digital Input Voltage to DGND . . . -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
\(\mathrm{I}_{\text {OUT }}\) to AGND . . . . . . . . . . . . . . . . . . . . . -0.3 V to \(\mathrm{V}_{\mathrm{DD}}\)
\(\mathrm{V}_{\mathrm{RFB}}\) to AGND . . . . . . . . . . . . . . . . . . . . . . . . . . \(\pm 35 \mathrm{~V}\)
AGND to DGND . . . . . . . . . . . . . . . . . . . . . . 0 to \(\mathrm{V}_{\text {DD }}\)
DGND to AGND . . . . . . . . . . . . . . . . . . . . . . . 0 to \(\mathrm{V}_{\text {DD }}\)
Power Dissipation, DIP
\(\theta_{\text {JA }}\), Thermal Impedance . . . . . . . . . . . . . . . . . . \(117^{\circ} \mathrm{C} / \mathrm{W}\)
Lead Temperature (Soldering, 10 secs) . . . . . . . . . \(+300^{\circ} \mathrm{C}\)
Power Dissipation, SOIC . . . . . . . . . . . . . . . . . . . . . . 1 W
\(\theta_{\text {JA }}\), Thermal Impedance . . . . . . . . . . . . . . . . . . \(75^{\circ} \mathrm{C} / \mathrm{W}\)
Lead Temperature (Soldering)
Vapor Phase ( 60 secs) . . . . . . . . . . . . . . . . . . . . \(215^{\circ} \mathrm{C}\)
\begin{tabular}{|c|c|}
\hline \multicolumn{2}{|l|}{Power Dissipation, LCCC} \\
\hline \(\theta_{\mathrm{JA}}\), Thermal Impedance & /W \\
\hline Lead Temperature (Soldering, 10secs) & \(300^{\circ} \mathrm{C}\) \\
\hline \multicolumn{2}{|l|}{Operating Temperature Range} \\
\hline Commercial (K, L Versions) & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) \\
\hline Industrial ( \(\mathrm{B}, \mathrm{C}\) Versions) & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) \\
\hline Extended (T, U Versions) & \(55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

\section*{ESD SUSCEPTIBILITY}

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 volts, which readily accumulate on the human body and on test equipment, can discharge without detection. Although these devices feature proprietary ESD protection circuitry, permanent damage may still occur on these devices if they are subjected to high energy electrostatic discharges. Therefore, proper precautions are recommended to avoid any performance degradation or loss of functionality.


\section*{ORDERING GUIDES}

AD7111A ORDERING GUIDE
\begin{tabular}{l|l|l|l}
\hline & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Specified \\
Accuracy \\
Range
\end{tabular} & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline Model & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 0 dB to 60 dB & \(\mathrm{~N}-16\) \\
AD7111ABN & \(-40^{\circ}\) to \(+85^{\circ} \mathrm{C}\) & 0 dB to 72 dB & \(\mathrm{~N}-16\) \\
AD7111ACN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 0 dB to 60 dB & \(\mathrm{R}-16\) \\
AD7111ABR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 0 dB to 72 dB & \(\mathrm{R}-16\) \\
\hline AD7111ACR & \(-40^{2}\) \\
\hline
\end{tabular}

NOTE
\({ }^{1} \mathrm{~N}=\) Plastic DIP; R = SOIC. For outline information see Package Information section.

\section*{TERMINOLOGY}

RESOLUTION: Nominal change in attenuation when moving between two adjacent codes.
MONOTONICITY: The device is monotonic if the analog output decreases (or remains constant) as the digital code increases.

FEEDTHROUGH ERROR: That portion of the input signal which reaches the output when all digital inputs are high. See section on Applications.
OUTPUT LEAKAGE CURRENT: Current which appears on the \(\mathrm{I}_{\text {Out }}\) terminal with all digital inputs high.
TOTAL HARMONIC DISTORTION: A measure of the harmonics introduced by the circuit when a pure sinusoid is applied to the input. It is expressed as the harmonic energy divided by the fundamental energy at the output.

AD7111 ORDERING GUIDE
\begin{tabular}{l|l|l|l}
\hline & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Specified \\
Accuracy \\
Range
\end{tabular} & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD7111KN & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & 0 dB to 60 dB & \(\mathrm{~N}-16\) \\
AD7111BQ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 0 dB to 60 dB & \(\mathrm{Q}-16\) \\
AD7111LN & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & 0 dB to 72 dB & \(\mathrm{~N}-16\) \\
AD7111CQ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 0 dB to 72 dB & \(\mathrm{Q}-16\) \\
AD7111UQ/883B & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 0 dB to 72 dB & \(\mathrm{Q}-16\) \\
AD7111TE/883B & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 0 dB to 60 dB & \(\mathrm{E}-20 \mathrm{~A}\) \\
\hline
\end{tabular}

NOTES
\({ }^{1}\) To order MIL-STD-883B, Class B processed parts, add /883B to part number. Contact local sales office for military data sheet and availability.
\({ }^{2} \mathrm{~N}=\) Plastic DIP; \(\mathrm{Q}=\) Cerdip; \(\mathrm{E}=\mathrm{LCCC} ; \mathrm{R}=\) SOIC. For outline information see Package Information section.

ACCURACY: The difference (measured in dB ) between the ideal transfer function as listed in Table I and the actual transfer function as measured with the device.

OUTPUT CAPACITANCE: Capacitance from \(\mathrm{I}_{\text {OUT }}\) to ground.
DIGITAL-TO-ANALOG GLITCH IMPULSE: The amount of charge injected from the digital inputs to the analog output when the inputs change state. This is normally specified as the area of the glitch in either pA-secs or nV -secs depending upon whether the glitch is measured as a current or voltage signal. Glitch impulse is measured with \(\mathrm{V}_{\mathrm{IN}}=\) AGND.
PROPAGATION DELAY: This is a measure of the internal delays of the circuit and is defined as the time from a digital input change to the analog output current reaching \(90 \%\) of its final value.


\section*{PIN CONFIGURATIONS}


\section*{CIRCUIT DESCRIPTION}

\section*{GENERAL CIRCUIT DESCRIPTION}

The AD7111/AD7111A consists of a 17-bit R-2R CMOS multiplying D/A converter with extensive digital logic. The logic translates the 8 -bit binary input into a 17 -bit word which is used to drive the \(\mathrm{D} / \mathrm{A}\) converter. Input data on the \(\mathrm{D} 7-\mathrm{D} 0\) bus is loaded into the input data latches using \(\overline{\mathrm{CS}}\) and \(\overline{\mathrm{WR}}\) control signals. When using the AD7111, the rising edge of \(\overline{\mathrm{WR}}\) latches the input data and initiates the internal data transfer to the decoder. A minimum time \(t_{\text {RFSH }}\), the refresh time, is required for the data to propagate through the decoder before a new data write is attempted.
In contrast, the AD7111A \(\overline{\mathrm{WR}}\) input is level triggered to allow transparent operation of the latches if required.
The transfer function for the circuit of Figure 1 is given by:
\[
\begin{gathered}
V_{O}=-V_{I N} 10 \exp -\frac{0.375 \mathrm{~N}}{20} \\
\text { or }\left|\frac{V_{O}}{V_{I N}}\right| d B=-0.375 \mathrm{~N}
\end{gathered}
\]
where 0.375 is the step size (resolution) in dB and N is the input code in decimal for values 0 to 239 . For \(240 \leq N \leq 255\) the output is zero. Table I gives the output attenuation relative to 0 dB for all possible input codes.


Figure 1. Typical Circuit Configuration
The graphs on the last page give a pictorial representation of the specified accuracy and monotonic ranges for all grades of the AD7111/AD7111A. High attenuation levels are specified with less accuracy than low attenuation levels. The range of monotonic behavior depends upon the attenuation step size used. For


Table I. Ideal Attenuation in dB vs. Input Code


\section*{AD7111/AD7111A - Applications Information}
example, the AD7111L is guaranteed monotonic in 0.375 dB steps from 0 dB to -54 dB inclusive and in 0.75 dB steps from 0 dB to -72 dB inclusive. To achieve monotonic operation over the entire 88.5 dB range it is necessary to select input codes so that the attenuation step size at any point is consistent with the step size guaranteed for monotonic operation at that point.

\section*{EQUIVALENT CIRCUIT ANALYSIS}

Figure 2 shows a simplified circuit of the D/A converter section of the AD7111/AD7111A, and Figure 3 gives an approximate equivalent circuit.
The current source \(I_{\text {LEAKAGE }}\) is composed of surface and junction leakages. The resistor \(\mathrm{R}_{0}\) as shown in Figure 3 is the equivalent output resistance of the device which varies with input code (excluding all 0 s code) from 0.8 R to 2 R . R is typically \(12 \mathrm{k} \Omega\). \(\mathrm{C}_{\text {OUT }}\) is the capacitance due to the N channel switches and varies from about 20 pF to 50 pF depending upon the digital input. For further information on CMOS multiplying D/A converters, refer to "CMOS DAC Application Guide" which is available from Analog Devices, Publication Number G872b-8-1/89.


Figure 2. Simplified D/A Circuit of AD7111/AD7111A


Figure 3. Equivalent Analog Output Circuit of AD7111/ AD7111A

\section*{DYNAMIC PERFORMANCE}

The dynamic performance of the AD7111/AD7111A will depend upon the gain and phase characteristics of the output amplifier, together with the optimum choice of PC board layout and decoupling components. Circuit layout is most important if the optimum performance of the AD7111/AD7111A is to be achieved. Most application probiems stem from either poor layout, grounding errors, or inappropriate choice of amplifier.
It is recommended that when using the AD7111/AD7111A with a high speed amplifier, a capacitor (C1) be connected in the feedback path as shown in Figure 1. This capacitor, which should be between 10 pF and 30 pF , compensates for the phase lag introduced by the output capacitance of the D/A converter.

Figures 4 and 5 show the performance of the AD7111/AD7111A using the AD711, a high speed, low cost BiFET amplifier, and the OP-275, a dual, bipolar/JFET, audio amplifier. The performance without Cl is shown in the middle trace and the response with C 1 in circuit shown in the bottom trace.


Figure 4. Response of AD7111/AD7111A with AD711


Figure 5. Response of AD7111/AD7111A with 1/2 OP-275
In conventional CMOS D/A converter design, parasitic capacitance in N -channel D/A converter switches can give rise to glitches on the D/A converter output. These glitches result from digital feedthrough. The AD7111/AD7111A has been designed to minimize these glitches as much as possible.
For operation beyond 250 kHz , capacitor Cl may be reduced in value. This gives an increase in bandwidth at the expense of a poorer transient response as shown in Figure 5. In circuits where C 1 is not included, the high frequency roll-off point is primarily determined by the characteristics of the output amplifier and not the AD7111/AD7111A.

Feedthrough and absolute accuracy are sensitive to output leakage current effects. For this reason it is recommended that the operating temperature of the AD7111/AD7111A be kept as close to \(25^{\circ} \mathrm{C}\) as is practically possible, particularly where the device's performance at high attenuation levels is important.
Some solder fluxes and cleaning materials cañ form slightly conductive films which cause leakage effects between analog input and output. The user is cautioned to ensure that the manufacturing process for circuits using the AD7111/AD7111A does not allow such films to form. Otherwise the feedthrough, accuracy and maximum usable range will be affected. LC²MOS LOGDAC Dual Logarithmic D/A Converter

\section*{FEATURES}

Dynamic Range: 88.5 dB
Resolution: 0.375 dB
On-Chip Data Latches for Both DACs
Four-Quadrant Multiplication
+5 V Operation
Pin Compatible with AD7528
Low Power

\section*{APPLICATIONS}

Audio Attenuators
Sonar Systems
Function Generators

\section*{GENERAL DESCRIPTION}

The LOGDAC \({ }^{\circledR}\) AD7112 is a monolithic dual multiplying D/A converter featuring wide dynamic range and excellent DAC-toDAC matching. Both DACs can attenuate an analog input signal over the range 0 to 88.5 dB in 0.375 dB steps. It is available in skinny \(0.3^{\prime \prime}\) wide 20 -pin DIPs and in 20 -terminal surface mount packages.
The degree of attenuation in either channel is determined by the 8 -bit word applied to the on-board decode logic. This 8 -bit word is decoded into a 17 -bit word which is then loaded into one of the 17 -bit data latches, determined by \(\overline{\mathrm{DACA}} / \mathrm{DACB}\). The fine step resolution over the entire dynamic range is due to the use of these 17 -bit DACs.
The AD7112 is easily interfaced to a standard 8 -bit MPU bus via an 8 -bit data port and standard microprocessor control lines. It should be noted that the AD7112 is exactly pin-compatible with the AD7528, an industry standard dual 8-bit multiplying DAC. This allows an easy upgrading of existing AD7528 designs which would benefit both from the wider dynamic range and the finer step resolution offered by the AD7112.
The AD7112 is fabricated in Linear Compatible CMOS ( \(\mathrm{LC}^{2} \mathrm{MOS}\) ), an advanced, mixed technology process that combines precision bipolar circuits with low power CMOS logic.

\footnotetext{
*Protected by U.S. Patent No. 4521764
LOGDAC is a registered trademark of Analog Devices, Inc.
}

FUNCTIONAL BLOCK DIAGRAM


\section*{PRODUCT HIGHLIGHTS}
1. DAC-to-DAC Matching: Since both of the AD7112 DACs are fabricated at the same time on the same chip, precise matching and tracking between the two DACs is inherent.
2. Small Package: The AD7112 is available in a 20 -pin DIP and a 20 -terminal SOIC package.
3. Fast Microprocessor Interface: The AD7112 has bus interface timing compatible with all modern microprocessors.

\footnotetext{
This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.
}
 \(V_{I N} B=10 \mathrm{~V}\). Output amplifier AD712 except where stated. All specifications \(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) unless otherwise noted.)


\footnotetext{
NOTES
\({ }^{1}\) Temperature Range as follows: B, C Versions: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\).
\({ }^{2}\) Guaranteed by design, not production tested.
\({ }^{3}\) The part will function with \(\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 10 \%\) with degraded performance.
Specifications subject to change without notice.
}

\begin{tabular}{|c|c|c|c|c|c|}
\hline Parameter & & \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) & \(\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & Units & Conditions/Comments \\
\hline \(\overline{\mathrm{CS}}\) to \(\overline{\mathrm{WR}}\) Setup Time & \({ }^{\text {tss }}\) & 0 & 0 & ns min & See Figure 3. \\
\hline \(\overline{\mathrm{CS}}\) to \(\overline{\mathrm{WR}}\) Hold Time & \(\mathrm{t}_{\mathrm{CH}}\) & 0 & 0 & ns min & \\
\hline DAC Select to \(\overline{\mathrm{WR}}\) Setup Time & \(\mathrm{t}_{\text {AS }}\) & 4 & 4 & ns min & \\
\hline DAC Select to \(\overline{\mathrm{WR}}\) Hold Time & \(\mathrm{t}_{\mathrm{AH}}\) & 0 & 0 & ns min & \\
\hline Data Valid to \(\overline{\mathrm{WR}}\) Setup Time & \(\mathrm{t}_{\mathrm{DS}}\) & 55 & 55 & ns min & \\
\hline Data Valid to \(\overline{\mathrm{WR}}\) Hold Time & \(\mathrm{t}_{\text {DH }}\) & 10 & 10 & \(n \mathrm{~ns}\) min & \\
\hline \(\overline{\text { WR Pulse Width }}\) & \(\mathrm{t}_{\mathrm{WR}}\) & 53 & 53 & \(n \mathrm{~ns}\) min & \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Timing specifications guaranteed by design not production tested. All input signals are specified with \(\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%\) to \(90 \%\) of 5 V\()\) and timed from a voltage level of 1.6 V .
Specifications subject to change without notice.

\section*{AC PERFORMANCE CHARACTERISTICS \({ }^{1}\left(V_{D D}=+5 V \pm 5 \% ;\right.\) OUT \(A=0 U T B=A G N D=D G N D=0 V ; V_{I N} A=\) \(\mathrm{V}_{\mathrm{IN}} \mathrm{B}=10 \mathrm{~V}\). Output amplifier AD712 except where noted.)}
\begin{tabular}{|c|c|c|c|c|}
\hline Parameter & \[
\begin{aligned}
& \mathrm{T}_{\mathrm{A}}= \\
& +25^{\circ} \mathrm{C}
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{T}_{\mathrm{A}}= \\
& -40^{\circ} \mathrm{C} \text { to } \\
& +85^{\circ} \mathrm{C}
\end{aligned}
\] & Units & Conditions/Comments \\
\hline DC Supply Rejection \(\Delta\) Gain/ \(\Delta \mathrm{V}_{\text {DD }}\) & 0.001 & 0.005 & \(\mathrm{dB} / \%\) max & \(\Delta V_{\text {DD }}= \pm 5 \%\). Input Code \(=00000000\) \\
\hline Digital-to-Analog Glitch Impulse & 10 & 10 & nV s typ & Measured with AD843 as output amplifier for input code transition 10000000 to 00000000 \\
\hline Output Capacitance, \(\mathrm{C}_{\text {OUT }}, \mathrm{C}_{\text {OUt }}\) & 50 & 50 & pF max & \\
\hline AC Feedthrough & & & & \\
\hline \(\mathrm{V}_{\text {IN }} \mathrm{A}\) to OUT A & -94 & -90 & dB max & \(\mathrm{V}_{\text {IN }} \mathrm{A}, \mathrm{V}_{\mathrm{IN}} \mathrm{B}=6 \mathrm{~V}\) rms at 1 kHz . DAC Registers loaded with all 1s. \\
\hline \(\mathrm{V}_{\text {IN }} \mathrm{B}\) to OUT B & -94 & -90 & dB max & \\
\hline Channel-to-Channel Isolation \(\mathrm{V}_{\mathrm{IN}} \mathrm{A}\) to OUT B & -87 & -87 & dB typ & \(\mathrm{V}_{\text {IN }} \mathrm{A}=6 \mathrm{~V} \mathrm{rms}\) at 10 kHz sine wave, \\
\hline \(V_{\text {IN }}\) A to OUT B & -87 & -87 & dB typ & \(\mathrm{V}_{\mathrm{IN}} \mathrm{B}=0 \mathrm{~V}\). DAC Registers loaded with all 0s. \\
\hline \(\mathrm{V}_{\text {IN }} \mathrm{B}\) to OUT A & -87 & -87 & dB typ & \(\mathrm{V}_{\mathrm{IN}} \mathrm{B}=6 \mathrm{~V} \mathrm{rms}\) at 10 kHz sine wave, \(\mathrm{V}_{\text {IN }} \mathrm{A}=0 \mathrm{~V}\). DAC Registers loaded with all 0 s . \\
\hline Digital Feedthrough & 1 & 1 & nV s typ & Measured with input code transitions of all 0 s to all 1 l . \\
\hline Output Noise Voltage Density ( 30 Hz to 50 kHz ) & 15 & 15 & \(\mathrm{nV} / \sqrt{\mathrm{Hz}}\) typ & Measured between \(\mathrm{R}_{\mathrm{FB}} \mathrm{A}\) and OUT A or between \(\mathrm{R}_{\mathrm{FB}} \mathrm{B}\) and OUT B. \\
\hline Total Harmonic Distortion & -91 & -91 & dB typ & \(\mathrm{V}_{\text {IN }} \mathrm{A}=\mathrm{V}_{\text {IN }} \mathrm{B}=6 \mathrm{~V}\) rms at 1 kHz . DAC Registers loaded with all 0s. \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Guaranteed by design, not production tested.
Specifications subject to change without notice.
\begin{tabular}{|c|c|}
\hline \multicolumn{2}{|l|}{ABSOLUTE MAXIMUM RATINGS*} \\
\hline \(\mathrm{V}_{\mathrm{DD}}\) to AGND or DGND & \(-0.3 \mathrm{~V},+7 \mathrm{~V}\) \\
\hline AGND to DGND & \(-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}\) \\
\hline Digital Inputs to DGND & \(-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}\) \\
\hline OUT A, OUT B to AGND & \(-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}\) \\
\hline \(\mathrm{V}_{\text {IN }} \mathrm{A}, \mathrm{V}_{\text {IN }} \mathrm{B}\) to AGND & \(\pm 25 \mathrm{~V}\) \\
\hline \(\mathrm{V}_{\mathrm{RFB}} \mathrm{A}, \mathrm{V}_{\mathrm{RFB}} \mathrm{B}\) to AGND & \(\pm 25 \mathrm{~V}\) \\
\hline \multicolumn{2}{|l|}{Operating Temperature Range} \\
\hline All Versions & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) \\
\hline Junction Temperature & \(+150^{\circ} \mathrm{C}\) \\
\hline Storage Temperature & \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\) \\
\hline Power Dissipation, DIP & 1 W \\
\hline \(\theta_{\mathrm{JA}}\), Thermal Impedance & \(102^{\circ} \mathrm{C} / \mathrm{W}\) \\
\hline
\end{tabular}

ABSOLUTE MAXIMUM RATINGS*
\(\mathrm{V}_{\mathrm{DD}}\) to AGND or DGND . . . . . . . . . . . . . \(-0.3 \mathrm{~V},+7 \mathrm{~V}\)
AGND to DGND . . . . . . . . . . . . . . . \(-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
Digital Inputs to DGND . . . . . . . . . \(-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
OUT A, OUT B to AGND . . . . . . . \(-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
\(\mathrm{V}_{\mathrm{IN}} \mathrm{A}, \mathrm{V}_{\mathrm{IN}} \mathrm{B}\) to AGND . . . . . . . . . . . . . . . . . . . . . \(\pm 25 \mathrm{~V}\)
\(\mathrm{V}_{\mathrm{RFB}} \mathrm{A}, \mathrm{V}_{\mathrm{RFB}}\) B to AGND . . . . . . . . . . . . . . . . . . . \(\pm 25\) V
Operating Temperature Range
All Versions . . . . . . . . . . . . . . . . . . . . . \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
Junction Temperature . . . . . . . . . . . . . . . . . . . . . . \(+150^{\circ} \mathrm{C}\)
Storage Temperature . . . . . . . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
\(\theta_{\mathrm{JA}}\), Thermal Impedance . . . . . . . . . . . . . . . . . . . \(102^{\circ} \mathrm{C} / \mathrm{W}\)

\footnotetext{
Lead Temperature (Soldering, 10 secs) . . . . . . . . . . . \(+300^{\circ} \mathrm{C}\)
Power Dissipation, SOIC . . . . . . . . . . . . . . . . . . . . . . 1 W
\(\theta_{\mathrm{JA}}\), Thermal Impedance . . . . . . . . . . . . . . . . . . . . \(75^{\circ} \mathrm{C} / \mathrm{W}\)
Lead Temperature (Soldering)
Vapor Phase (60 secs) . . . . . . . . . . . . . . . . . . . . . . \(215^{\circ} \mathrm{C}\)
Infrared ( 15 secs) . . . . . . . . . . . . . . . . . . . . . . . . . \(220^{\circ} \mathrm{C}\)
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Only one Absolute Maximum Rating may be applied at any one time.
}

\section*{ESD SUSCEPTIBILITY}

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 volts, which readily accumulate on the human body and on test equipment, can discharge without detection. Although devices feature proprietary ESD protection circuitry, permanent damage may still occur on these devices if they are subjected to high energy electrostatic discharges. Therefore, proper precautions are recommended to avoid any performance degradation or loss of functionality.


\section*{TERMINOLOGY}

RESOLUTION: Nominal change in attenuation when moving between two adjacent codes.

MONOTONICITY: The device is monotonic if the analog output decreases or remains constant as the digital code increases.
FEEDTHROUGH ERROR: That portion of the input signal which reaches the output when all digital inputs are high.
OUTPUT CAPACITANCE: Capacitance from OUT A or OUT B to ground.
GAIN ERROR: Gain error results from a mismatch between \(\mathrm{R}_{\mathrm{FB}}\) (the feedback resistance) and the \(\mathrm{R}-2 \mathrm{R}\) ladder resistance. Its effect in a LOGDAC is to produce a constant additive attenuation error in dB over the whole range of the DAC.
ACCURACY: The difference (measured in dB ) between the ideal transfer function as listed in Table I and the actual transfer function as measured with the device.

DIGITAL-TO-ANALOG GLITCH IMPULSE: The amount of charge injected from the digital inputs to the analog output when the inputs change state. This is normally specified as the area of the glitch in either pA-s or nV -s depending on whether the glitch is measured as a current or voltage signal. Glitch impulse is measured with \(\mathrm{V}_{\mathrm{IN}}=\mathrm{AGND}\).

ORDERING GUIDE
\begin{tabular}{l|l|l|l}
\hline Model & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Specified \\
Accuracy \\
Range
\end{tabular} & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD7112BN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 0 dB to 60 dB & \(\mathrm{~N}-20\) \\
AD7112CN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 0 dB to 72 dB & \(\mathrm{~N}-20\) \\
AD7112BR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 0 dB to 60 dB & \(\mathrm{R}-20\) \\
AD7112CR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 0 dB to 72 dB & \(\mathrm{R}-20\) \\
\hline
\end{tabular}

\footnotetext{
\({ }^{\star} \mathrm{N}=\) Plastic DIP; R = SOIC. For outline information see Package Information section.
}

\section*{PIN FUNCTION DESCRIPTION}
\begin{tabular}{lll}
\hline Pin & Mnemonic & Description \\
\hline 1 & AGND & Analog Ground. \\
2 & OUT A & Current Output Terminal of DAC A. \\
3 & \(\mathrm{R}_{\mathrm{FB}} \mathrm{A}\) & Feedback Resistor for DAC A. \\
4 & \(\mathrm{~V}_{\mathrm{IN}} \mathrm{A}\) & Reference Input to DAC A \\
5 & DGND & Digital Ground. \\
6 & \(\overline{\mathrm{DAC} \mathrm{A}} /\) & Selects Which DAC Can Accept Data from \\
& DAC B & Input Port. \\
\(7-14\) & \(\mathrm{DB} 7-\mathrm{DB} 0\) & 8 Data Inputs. \\
15 & \(\overline{\mathrm{CS}}\) & Chip Select Input, Active Low. \\
16 & \(\overline{\mathrm{WR}}\) & Write Input, Active Low. \\
17 & \(\mathrm{~V}_{\mathrm{DD}}\) & Power Supply Input 5 V \(\pm 5 \%\). \\
18 & \(\mathrm{~V}_{\mathrm{IN}} \mathrm{B}\) & Reference Input to DAC B. \\
19 & \(\mathrm{R}_{\mathrm{FB}} \mathrm{B}\) & Feedback Resistor for DAC B. \\
20 & OUT B & Current Output Terminal of DAC B. \\
\hline
\end{tabular}

\section*{PIN CONFIGURATION} DIP/SOIC


\section*{CIRCUIT DESCRIPTION}

\section*{GENERAL CIRCUIT INFORMATION}

The AD7112 consists of a dual 17-bit R-2R CMOS multiplying D/A converter with extensive digital logic. Figure 1 shows a simplified circuit of the D/A converter section of the AD7112. The logic translates the 8 -bit binary input into a 17 -bit word which is used to drive the D/A converter. Figure 2 shows a typical circuit configuration for the AD7112.
The transfer function for the circuit of Figure 2 is given by:
\[
V_{O}=-V_{I N} \times 10 \exp -\frac{0.375 \mathrm{~N}}{20}
\]
or
\[
\left|\frac{V_{O}}{V_{I N}}\right| d B=-0.375 N
\]
where 0.375 is the step size (resolution) in dB and \(N\) is the input code in decimal for values 0 to 239 . For \(240 \leq N \leq 255\) the output is zero. Table I gives the output attenuation relative to 0 dB for all possible input codes.


Figures 16 and 17 give a pictorial representation of the specified accuracy and monotonic ranges for all grades of the AD7112.
High attenuation levels are specified with less accuracy than low attenuation levels. The range of monotonic behavior depends upon the attenuation step size used. To achieve monotonic operation over the entire 88.5 dB range, it is necessary to select input codes so that the attenuation step size at any point is consistent with the step size guaranteed for monotonic operation at that point.


Figure 2. Typical Circuit Configuration

Figure 1. Simplified D/A Circuit of \(1 / 2\) AD7112
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \[
D_{3} D_{0}
\] & \multicolumn{16}{|c|}{Table I. Ideal Attenuation in dB vs. Input Code} \\
\hline D7-D4 & 0000 & 0001 & 0010 & 0011 & 0100 & 0101 & 0110 & 0111 & 1000 & 1001 & 1010 & 1011 & 1100 & 1101 & 1110 & 1111 \\
\hline 0000 & 0.000 & 0.375 & 0.750 & 1.125 & 1.500 & 1.875 & 2.250 & 2.625 & 3.000 & 3.375 & 3.750 & 4.125 & 4.500 & 4.875 & 5.250 & 5.625 \\
\hline 0001 & 6.000 & 6.375 & 6.750 & 7.125 & 7.500 & 7.875 & 8.250 & 8.625 & 9.000 & 9.375 & 9.750 & 10.125 & 10.500 & 10.875 & 11.250 & 11.625 \\
\hline 0010 & 12.000 & 12.375 & 12.750 & 13.125 & 13.500 & 13.875 & 14.250 & 14.625 & 15.000 & 15.375 & 15.750 & 16.125 & 16.500 & 16.875 & 17.250 & 17.625 \\
\hline 0011 & 18.000 & 18.375 & 18.750 & 19.125 & 19.500 & 19.875 & 20.250 & 20.625 & 21.000 & 21.375 & 21.750 & 22.125 & 22.500 & 22.875 & 23.250 & 23.625 \\
\hline 0100 & 24.000 & 24.375 & 24.750 & 25.125 & 25.500 & 25.875 & 26.250 & 26.625 & 27.000 & 27.375 & 27.750 & 28.125 & 28.500 & 28.875 & 29.250 & 29.625 \\
\hline 0101 & 30.000 & 30.375 & 30.750 & 31.125 & 31.500 & 31.875 & 32.250 & 32.625 & 33.000 & 33.375 & 33.750 & 34.125 & 34.500 & 34.875 & 35.250 & 35.625 \\
\hline 0110 & 36.000 & 36.375 & 36.750 & 37.125 & 37.500 & 37.875 & 38.250 & 38.625 & 39.000 & 39.375 & 39.750 & 40.125 & 40.500 & 40.875 & 41.250 & 41.625 \\
\hline 0111 & 42.000 & 42.375 & 42.750 & 43.125 & 43.500 & 43.875 & 44.250 & 44.625 & 45.000 & 45.375 & 45.750 & 46.125 & 46.500 & 46.875 & 47.250 & 47.625 \\
\hline 1000 & 48.000 & 48.375 & 48.750 & 49.125 & 49.500 & 49.875 & 50.250 & 50.625 & 51.000 & 51.375 & 51.750 & 52.125 & 52.500 & 52.875 & 53.250 & 53.625 \\
\hline 1001 & 54.000 & 54.375 & 54.750 & 55.125 & 55.500 & 55.875 & 56.250 & 56.625 & 57.000 & 57.375 & 57.750 & 58.125 & 58.500 & 58.875 & 59.250 & 59.625 \\
\hline 1010 & 60.000 & 60.375 & 60.750 & 61.125 & 61.500 & 61.875 & 62.250 & 62.625 & 63.000 & 63.375 & 63.750 & 64.125 & 64.500 & 64.875 & 65.250 & 65.625 \\
\hline 1011 & 66.000 & 66.375 & 66.750 & 67.125 & 67.500 & 67.875 & 68.250 & 68.625 & 69.000 & 69.375 & 69.750 & 70.125 & 70.500 & 70.875 & 71.250 & 71.625 \\
\hline 1100 & 72.000 & 72.375 & 72.750 & 73.125 & 73.500 & 73.875 & 74.250 & 74.625 & 75.000 & 75.375 & 75.750 & 76.125 & 76.500 & 76.875 & 77.250 & 77.625 \\
\hline 1101 & 78.000 & 78.375 & 78.750 & 79.125 & 79.500 & 79.875 & 80.250 & 80.625 & 81.000 & 81.375 & 81.750 & 82.125 & 82.500 & 82.875 & 83.250 & 83.625 \\
\hline 1110 & 84.000 & 84.375 & 84.750 & 85.125 & 85.500 & 85.875 & 86.250 & 86.625 & 87.000 & 87.375 & 87.750 & 88.125 & 88.500 & 88.875 & 89.250 & 89.625 \\
\hline 1111 & MUTE & MUTE & MUTE & MUTE & MUTE & MUTE & MUTE & MUTE & MUTE & MUTE & MUTE & MUTE & MUTE & MUTE & MUTE & MUTE \\
\hline
\end{tabular}

\section*{INTERFACE LOGIC INFORMATION}

\section*{DAC Selection}

Both DAC latches share a common 8-bit port. The control input \(\overline{\text { DAC A }} / \mathrm{DAC}\) B selects which DAC can accept data from the input port.

\section*{Mode Selection}

Inputs \(\overline{\mathrm{CS}}\) and \(\overline{\mathrm{WR}}\) control the operating mode of the selected DAC. See the Mode Selection Table below.

\section*{Write Mode}

When \(\overline{\mathrm{CS}}\) and \(\overline{\mathrm{WR}}\) are both low the DAC is in the write mode. The input data latches of the selected DAC are transparent and its analog output responds to activity on DB0-DB7.

\section*{Hold Mode}

The selected DAC latch retains the data which was present on DB0-DB7 just prior to \(\overline{\mathrm{CS}}\) and \(\overline{\mathrm{WR}}\) assuming a high state. Both analog outputs remain at the values corresponding to the data in their respective latches.

Mode Selection Table
\begin{tabular}{|c|c|c|c|c|}
\hline \begin{tabular}{l}
\(\overline{\text { DAC A }} /\) \\
DAC B
\end{tabular} & \(\overline{\mathrm{CS}}\) & \(\overline{\text { WR }}\) & DAC A & DAC B \\
\hline L & L & L & WRITE & HOLD \\
\hline H & L & L & HOLD & WRITE \\
\hline X & H & X & HOLD & HOLD \\
\hline X & X & H & HOLD & HOLD \\
\hline
\end{tabular}
\(\mathrm{L}=\) Low State, \(\mathrm{V}_{\mathrm{IL}} ; \mathrm{H}=\) High State, \(\mathrm{V}_{\mathrm{IH}} ; \mathrm{X}=\) Don't Care.


Figure 3. Write Cycle Timing Diagram

\section*{DYNAMIC PERFORMANCE}

The dynamic performance of the AD7112 will depend on the gain and phase characteristics of the output amplifier, together with the optimum choice of PC board layout and decoupling components. Circuit layout is most important if the optimum performance of the AD7112 is to be achieved. Most application problems stem from either poor layout, grounding errors, or inappropriate choice of amplifier. Ensure that the layout of the printed circuit board has the digital and analog lines separated as much as possible. Take care not to run any digital track alongside an analog signal track. Establish a single point analog ground (star ground) separate from the logic system ground. Place this ground as close as possible to the AD7112. Connect all analog grounds to this star ground, and also connect the AD7112 DGND to this ground. Do not connect any other digital grounds to this analog ground point. Low impedance analog and digital power supply common returns are essential for low noise and high performance of these converters, therefore the foil width of these tracks should be as wide as possible. The use of ground planes is recommended as this minimizes impedance paths and also guards the analog circuitry from digital noise.
It is recommended that when using the AD7112 with a high speed amplifier, a capacitor (C1) be connected in the feedback path as shown in Figure 2. This capacitor which should be between 5 pF and 15 pF , compensates for the phase lag introduced by the output capacitance of the D/A converter. Figures 4 and 5 show the performance of the AD7112 using the AD712, a high speed, low cost BIFET amplifier, and the OP-275, a dual bipolar/JFET amplifier suitable for audio applications. The performance with and without the compensation capacitor is shown in both cases. For operation beyond 250 kHz , capacitor Cl may be reduced in value. This gives an increase in bandwidth at the expense of a poorer transient response as shown in Figure 7. In circuits where Cl is not included, the high frequency roll-off point is primarily determined by the characteristics of the output amplifier and not the AD7112.
Feedthrough and accuracy are sensitive to output leakage currents effects. For this reason it is recommended that the operating temperature of the AD7112 be kept as close to \(25^{\circ} \mathrm{C}\) as is practically possible, particularly where the devices performance at high attenuation levels is important. A typical plot of leakage current vs. temperature is shown in Figure 11.
Some solder fluxes and cleaning materials can form slightly conductive films which cause leakage effects between analog input and output. The user is cautioned to ensure that the manufacturing process for circuits using the AD7112 does not allow such films to form. Otherwise the feedthrough, accuracy and maximum usable range will be affected.

\section*{STATIC ACCURACY PERFORMANCE}

The D/A converter section of the AD7112 consists of a 17-bit R-2R type converter. To obtain optimum static performance at this level of resolution it is necessary to pay great attention to amplifier selection, circuit grounding, etc.
Amplifier input bias current results in a dc offset at the output of the amplifier due to current flowing in the feedback resistor \(\mathbf{R}_{\mathrm{FB}}\). It is recommended that amplifiers with input bias currents of less than 10 nA be used (e.g., AD712) to minimize this offset.

Another error arises from the output amplifier's input offset voltage. The amplifier is operated with a fixed feedback resistance, but the equivalent source impedance (the AD7112 output impedance) varies as a function of the attenuation level. This has the effect of varying the noise gain of the amplifier thus creating a varying error due to amplifier offset voltage. It is recommended that an amplifier with less than \(50 \mu \mathrm{~V}\) of input offset be used (such as the AD712 or ADOP-07) in dc applications.
Amplifiers with a large input offset voltage may cause audible thumps in audio applications due to dc output changes. The

\section*{TYPICAL PERFORMANCE CHARACTERISTICS}


Figure 4. Response of AD7112 with AD712


Figure 5. Response of AD7112 with OP-275

AD7112 accuracy is specified and tested using only the internal feedback resistor. Any Gain error (i.e., mismatch of \(\mathrm{R}_{\mathrm{FB}}\) to the R-2R ladder) that may exist in the AD7112 D/A converter circuit results in a constant attenuation error over the whole range. The AD7112 accuracy is specified relative to 0 dB attenuation, hence gain trim resistors can be used to adjust \(\mathrm{V}_{\text {OUt }}=\mathrm{V}_{\text {IN }}\) precisely (i.e., 0 dB attenuation) with input code 00000000 . For further information on gain error refer to the "CMOS DAC Application Guide" which is available from Analog Devices, Publication Number G872b-8-1/89.


Figure 6. Supply Current vs. Logic Input Level


Figure 7. Frequency Response with AD712 and OP-275


Figure 8. Distortion vs. Frequency


Figure 9. Feedthrough vs. Frequency


Figure 10. Channel-to-Channel Isolation vs. Frequency


Figure 11. Output Leakage Current vs. Temperature


Figure 12. Digital-to-Analog Glitch Impulse


Figure 13. Noise Spectral Density vs. Frequency

ANALOG DEVICES

\section*{FEATURES}

\author{
8-Bit CMOS DAC with Output Amplifier Operates with Single or Dual Supplies Low Total Unadjusted Error: Less than 1 LSB Over Temperature Extended Temperature Range Operation \(\mu\) P-Compatible with Double Buffered Input Standard 18-Pin DIPs and 20-Terminal Surface Mount Package and SOIC Package
}

\section*{GENERAL DESCRIPTION}

The AD7224 is a precision 8-bit, voltage-output, digital-to-analog converter with output amplifier and double buffered interface logic on a monolithic CMOS chip. No external trims are required to achieve full specified performance for the part.
The double buffered interface logic consists of two 8-bit registersan input register and a DAC register. Only the data held in the DAC register determines the analog output of the converter. The double buffering allows simultaneous update in a system containing multiple AD7224's. Both registers may be made transparent under control of three external lines, \(\overline{\mathrm{CS}}, \overline{\mathrm{WR}}\) and \(\overline{\text { LDAC. With both registers transparent, the } \overline{\text { RESET }} \text { line functions }}\) like a zero override; a useful function for system calibration cycles. All logic inputs are TTL and CMOS (5V) level compatible and the control logic is speed compatible with most 8 -bit microprocessors.
Specified performance is guaranteed for input reference voltages from +2 V to +12.5 V when using dual supplies. The part is also specified for single supply operation using a reference of +10 V . The output amplifier is capable of developing +10 V across a \(2 \mathrm{k} \Omega\) load.

The AD7224 is fabricated in an all ion-implanted high speed Linear Compatible CMOS (LC \({ }^{2}\) MOS) process which has been specifically developed to allow high speed digital logic circuits and precision analog circuits to be integrated on the same chip.

FUNCTIONAL BLOCK DIAGRAM


\section*{PRODUCT HIGHLIGHTS}
1. DAC and Amplifier on CMOS Chip

The single-chip design of the 8-bit DAC and output amplifier is inherently more reliable than multi-chip designs. CMOS fabrication means low power consumption ( 35 mW typical with single supply).
2. Low Total Unadjusted Error

The fabrication of the AD7224 on Analog Devices Linear Compatible CMOS ( \(\mathrm{LC}^{2} \mathrm{MOS}\) ) process, coupled with a novel DAC switch-pair arrangement, enables an excellent total unadjusted error of less than 1LSB over the full operating temperature range.
3. Single or Dual Supply Operation

The voltage-mode configuration of the AD7224 allows operation from a single power supply rail. The part can also be operated with dual supplies giving enhanced performance for some parameters.
4. Versatile Interface Logic

The high speed logic allows direct interfacing to most microprocessors. Additionally, the double buffered interface enables simultaneous update of the AD7224 in multiple DAC systems. The part also features a zero override function.

This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

\section*{AD7224-SPECIFICATIONS}

\section*{DUAL SUPPLY}
\(\left(V_{D D}=11.4 \mathrm{~V}\right.\) to \(16.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=-5 \mathrm{~V} \pm 10 \%\); AGND \(=\mathrm{DGND}=0 \mathrm{~V} ; \mathrm{V}_{\mathrm{REF}}+2 \mathrm{~V}\) to \(\left(\mathrm{V}_{\mathrm{DD}}-4 \mathrm{~V}\right)^{1}\) unless otherwise stated. All specifications \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) unless otherwise noted.)
\begin{tabular}{|c|c|c|c|c|}
\hline Parameter & \[
\underset{\text { Versions }}{\mathbf{K}, \mathbf{B}, \mathbf{T}}
\] & L, C, U Versions & Units & Conditions/Comments \\
\hline \begin{tabular}{l}
STATIC PERFORMANCE \\
Resolution \\
Total Unadjusted Error \\
Relative Accuracy \\
Differential Nonlinearity \\
Full Scale Error \\
Full Scale Temperature Coefficient \\
Zero Code Error \\
Zero Code Error Temperature Coefficient
\end{tabular} & \[
\begin{aligned}
& 8 \\
& \pm 2 \\
& \pm 1 \\
& \pm 1 \\
& \pm 3 / 2 \\
& \pm 20 \\
& \pm 30 \\
& \pm 50 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 8 \\
& \pm 1 \\
& \pm 1 / 2 \\
& \pm 1 \\
& \pm 1 \\
& \pm 20 \\
& \pm 20 \\
& \pm 30 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
Bits \\
LSB max \\
LSB max \\
LSB max \\
LSB max \\
\(\mathrm{ppm} /{ }^{\circ} \mathrm{C}\) max \\
\(m V\) max \\
\(\mu \mathrm{V} /{ }^{\circ} \mathrm{C}\) typ
\end{tabular} & \begin{tabular}{l}
\[
\mathrm{V}_{\mathrm{DD}}=+15 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{REF}}=+10 \mathrm{~V}
\] \\
Guaranteed Monotonic
\[
\mathrm{V}_{\mathrm{DD}}=14 \mathrm{~V} \text { to } 16.5 \mathrm{~V}, \mathrm{~V}_{\text {REF }}=+10 \mathrm{~V}
\]
\end{tabular} \\
\hline \begin{tabular}{l}
REFERENCE INPUT \\
Voltage Range Input Resistance Input Capacitance \({ }^{3}\)
\end{tabular} & \[
\begin{aligned}
& 2 \text { to }\left(V_{D D}-4\right) \\
& 8 \\
& 100
\end{aligned}
\] & \[
\begin{aligned}
& 2 \text { to }\left(V_{D D}-4\right) \\
& 8 \\
& 100
\end{aligned}
\] & \[
\begin{aligned}
& V_{\text {min }} \text { to } V_{\text {max }} \\
& \mathrm{k} \Omega \text { min } \\
& \mathrm{pF} \text { max }
\end{aligned}
\] & Occurs when DAC is loaded with all l's. \\
\hline DIGITALINPUTS Input High Voltage, \(\mathrm{V}_{\text {INH }}\) Input Low Voltage, \(\mathrm{V}_{\text {INL }}\) Input Leakage Current Input Capacitance \({ }^{3}\) Input Coding & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 1 \\
& 8 \\
& \text { Binary }
\end{aligned}
\] & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 1 \\
& 8 \\
& \text { Binary }
\end{aligned}
\] & \begin{tabular}{l}
\(V\) min \\
\(V_{\text {max }}\) \\
\(\mu \mathrm{A}\) max \\
pF max
\end{tabular} & \(\mathrm{V}_{\mathrm{IN}}=\mathbf{0}\) or \(\mathrm{V}_{\mathrm{DD}}\) \\
\hline DYNAMICPERFORMANCE Voltage Output Slew Rate \({ }^{3}\) Voltage Output Settling Time \({ }^{3}\) Positive Full Scale Change Negative Full Scale Change Digital Feedthrough Minimum Load Resistance & \[
\begin{aligned}
& 2.5 \\
& 5 \\
& 7 \\
& 50
\end{aligned}
\] & \[
\begin{aligned}
& 2.5 \\
& 5 \\
& 7 \\
& 50
\end{aligned}
\] & \begin{tabular}{l}
\(\mathrm{V} / \mathrm{Hs}_{\mathrm{sin}}\) \\
\(\mu \mathrm{s}\) max \\
\(\mu \mathrm{s}\) max \\
nV secs typ \\
\(\mathrm{k} \Omega\) min
\end{tabular} & \[
\begin{aligned}
& V_{\text {REF }}=+10 \mathrm{~V} \text {; Settling Time to } \pm 1 / 2 \mathrm{LSB} \\
& V_{\text {REF }}=+10 \mathrm{~V} \text {; Settling Time to } \pm 1 / 2 \mathrm{LSB} \\
& \mathrm{~V}_{\text {REF }}=0 \mathrm{~V} \\
& \mathrm{~V}_{\text {OUT }}=+10 \mathrm{~V} \\
& \hline
\end{aligned}
\] \\
\hline \begin{tabular}{l}
POWER SUPPLIES \\
\(V_{\text {DD }}\) Range \\
\(V_{\text {ss }}\) Range \\
IDD \\
\(@ 25^{\circ} \mathrm{C}\) \\
\(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) \\
Iss \\
@ \(25^{\circ} \mathrm{C}\) \\
\(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\)
\end{tabular} & \[
\begin{aligned}
& 11.4 / 16.5 \\
& 4.5 / 5.5 \\
& 4 \\
& 6
\end{aligned}
\] & \[
\begin{aligned}
& 11.4 / 16.5 \\
& 4.5 / 5.5 \\
& 4 \\
& 6 \\
& 3 \\
& 5 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
\(\mathrm{V}_{\text {min }} / \mathrm{V}_{\text {max }}\) \(\mathrm{V}_{\text {min }} / \mathrm{V}_{\text {max }}\) \\
mA max mA max \\
mA max \\
mA max
\end{tabular} & \begin{tabular}{l}
For Specified Performance \\
For Specified Performance \\
Outputs Unloaded; \(\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {INL }}\) or \(\mathrm{V}_{\text {INH }}\) \\
Outputs Unloaded; \(\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {INL }}\) or \(\mathrm{V}_{\text {INH }}\) \\
Outputs Unloaded; \(\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {INL }}\) or \(\mathrm{V}_{\text {INH }}\) \\
Outputs Unloaded; \(\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {INL }}\) or \(\mathrm{V}_{\text {INH }}\)
\end{tabular} \\
\hline  & & & ns min ns min & Chip Select/Load DAC Pulse Width \\
\hline \[
\begin{aligned}
& \mathrm{t}_{2} \\
& @ 25^{\circ} \mathrm{C} \\
& \mathrm{~T}_{\min } \text { to } \mathrm{T}_{\text {max }}
\end{aligned}
\] & \[
\begin{aligned}
& 90 \\
& 90
\end{aligned}
\] & \[
\begin{array}{r}
90 \\
90
\end{array}
\] & ns min ns min & Write/Reset Pulse Width \\
\hline \[
\begin{aligned}
& \mathrm{t}_{3} @ 25^{\circ} \mathrm{C} \\
& \mathrm{~T}_{\text {min }} \text { to } \mathrm{T}_{\text {max }}
\end{aligned}
\] & 0 & 0 & ns min ns min & Chip Select/Load DAC to Write Setup Time \\
\hline \[
\begin{aligned}
& \mathrm{t}_{4} \\
& \varrho 25^{\circ} \mathrm{C} \\
& \mathrm{~T}_{\text {min }} \text { to } \mathrm{T}_{\text {max }}
\end{aligned}
\] & \[
\begin{aligned}
& 0 \\
& 0
\end{aligned}
\] & 0 & ns min ns min & Chip Select/Load DAC to Write Hold Time \\
\hline \[
\begin{aligned}
& \mathrm{t}_{5} @ 25^{\circ} \mathrm{C} \\
& \mathrm{~T}_{\text {min }} \text { to } \mathrm{T}_{\text {max }}
\end{aligned}
\] & \[
\begin{aligned}
& 90 \\
& 90
\end{aligned}
\] & \[
\begin{aligned}
& 90 \\
& 90
\end{aligned}
\] & ns min ns min & Data Valid to Write Setup Time \\
\hline \(t_{6}\)
\[
\begin{aligned}
& @ 25^{\circ} \mathrm{C} \\
& \mathrm{~T}_{\text {min }} \text { to } \mathrm{T}_{\text {max }}
\end{aligned}
\] & \[
\begin{aligned}
& 10 \\
& 10
\end{aligned}
\] & \[
\begin{aligned}
& 10 \\
& 10
\end{aligned}
\] & ns \(\min\) ns min & Data Valid to Write Hold Time \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Maximum possible reference voltage.
\({ }^{2}\) Temperature ranges are as follows:
K, L Versions: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
B, C Versions: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
\(\mathrm{T}, \mathrm{U}\) Versions: \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
\({ }^{3}\) Sample Tested at \(25^{\circ} \mathrm{C}\) by Product Assurance to ensure compliance.
\({ }^{4}\) Switching characteristics apply for single and dual supply operation.
Specifications subject to change without notice.
 SNGLE SUPRL \(\mathrm{I}_{\text {mix }}\) to \(\mathrm{I}_{\text {max }}\) unless otherwise noted.)
\begin{tabular}{|c|c|c|c|c|}
\hline Parameter & \[
\underset{\text { Versions }^{2}}{\mathbf{K}, \mathbf{B}, \mathbf{T}}
\] & L, C, U Versions & Units & Conditions/Comments \\
\hline \begin{tabular}{l}
STATICPERFORMANCE \\
Resolution \\
Total Unadjusted Error Differential Nonlinearity
\end{tabular} & \[
\begin{aligned}
& 8 \\
& \pm 2 \\
& \pm 1
\end{aligned}
\] & \[
\begin{aligned}
& 8 \\
& \pm 2 \\
& \pm 1
\end{aligned}
\] & \begin{tabular}{l}
Bits \\
LSB max \\
LSB max
\end{tabular} & Guaranteed Monotonic \\
\hline \begin{tabular}{l}
REFERENCE INPUT \\
Input Resistance Input Capacitance \({ }^{3}\)
\end{tabular} & \[
\begin{aligned}
& 8 \\
& 100
\end{aligned}
\] & \[
\begin{aligned}
& 8 \\
& 100
\end{aligned}
\] & \(k \Omega\) min pF max & Occurs when DAC is loaded with all 1's. \\
\hline DIGITALINPUTS Input High Voltage, \(\mathrm{V}_{\text {INH }}\) Input Low Voltage, \(\mathrm{V}_{\text {INL }}\) Input Leakage Current Input Capacitance \({ }^{3}\) Input Coding & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 1 \\
& 8 \\
& \text { Binary } \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 1 \\
& 8 \\
& \text { Binary } \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
\(V\) min \\
\(V_{\text {max }}\) \\
\(\mu \mathrm{A}\) max \\
pF max
\end{tabular} & \(\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}\) or \(\mathrm{V}_{\mathrm{DD}}\) \\
\hline DYNAMIC PERFORMANCE Voltage Output Slew Rate \({ }^{4}\) Voltage Output Settling Time \({ }^{4}\) Positive Full Scale Change Negative Full Scale Change Digital Feedthrough \({ }^{3}\) Minimum Load Resistance & \[
\begin{aligned}
& 2 \\
& 5 \\
& 20 \\
& 50 \\
& 2
\end{aligned}
\] & \[
\begin{aligned}
& 2 \\
& 5 \\
& 20 \\
& 50 \\
& 2
\end{aligned}
\] & \begin{tabular}{l}
V/us min \\
\(\mu_{\text {s max }}\) \\
\(\mu \mathrm{s}\) max \\
nV secs typ \\
\(\mathrm{k} \Omega\) min
\end{tabular} & \[
\begin{aligned}
& \text { Settling Time to } \pm 1 / 2 \mathrm{LSB} \\
& \text { Settling Time to } \pm 1 / 2 \mathrm{LSB} \\
& \mathrm{~V}_{\mathrm{REF}}=0 \mathrm{~V} \\
& \mathrm{~V}_{\mathrm{OUT}}=+10 \mathrm{~V}
\end{aligned}
\] \\
\hline ```
POWER SUPPLIES
    \(V_{\text {DD }}\) Range
    \(I_{D D}\)
        \(@ 25^{\circ} \mathrm{C}\)
        \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\)
``` & \[
\begin{aligned}
& 14.25 / 15.75 \\
& 4 \\
& 6
\end{aligned}
\] & \[
\begin{aligned}
& 14.25 / 15.75 \\
& 4 \\
& 6
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{V}_{\text {min }} / \mathrm{V}_{\text {max }} \\
& \mathrm{mA} \max \\
& \mathrm{~mA} \max
\end{aligned}
\] & \begin{tabular}{l}
For Specified Performance \\
Outputs Unloaded; \(\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {INL }}\) or \(\mathrm{V}_{\text {INH }}\) \\
Outputs Unloaded; \(\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {INL }}\) or \(\mathrm{V}_{\text {INH }}\)
\end{tabular} \\
\hline ```
SWITCHINGCHARACTERISTICS }\mp@subsup{}{}{3,4
    t
        @25`
        T
``` & \[
\begin{aligned}
& 90 \\
& 90
\end{aligned}
\] & \[
\begin{aligned}
& 90 \\
& 90
\end{aligned}
\] & ns min ns min & Chip Select/Load DAC Pulse Width \\
\hline \[
\begin{aligned}
& \mathrm{t}_{2} @ 25^{\circ} \mathrm{C} \\
& \mathrm{~T}_{\text {min }} \text { to } \mathrm{T}_{\text {max }}
\end{aligned}
\] & \[
\begin{aligned}
& 90 \\
& 90
\end{aligned}
\] & \[
\begin{aligned}
& 90 \\
& 90
\end{aligned}
\] & ns min ns min & Write/Reset Pulse Width \\
\hline \[
\begin{aligned}
& \mathrm{t}_{3} @ 25^{\circ} \mathrm{C} \\
& \mathrm{~T}_{\text {min }} \text { to } \mathrm{T}_{\text {max }}
\end{aligned}
\] & 0 & \[
\begin{aligned}
& 0 \\
& 0
\end{aligned}
\] & ns min ns min & Chip Select/Load DAC to Write Setup Time \\
\hline \[
\begin{aligned}
& \mathrm{t}_{4} @ 25^{\circ} \mathrm{C} \\
& \mathrm{~T}_{\min } \text { to } \mathrm{T}_{\max }
\end{aligned}
\] & 0 & \[
\begin{aligned}
& 0 \\
& 0
\end{aligned}
\] & ns min ns \(\min ^{n}\) & Chip Select/Load DAC to Write Hold Time \\
\hline \[
\begin{aligned}
& \mathrm{t}_{5} @ 25^{\circ} \mathrm{C} \\
& \mathrm{~T}_{\text {min }} \text { to } \mathrm{T}_{\text {max }}
\end{aligned}
\] & \[
\begin{aligned}
& 90 \\
& 90
\end{aligned}
\] & \[
\begin{aligned}
& 90 \\
& 90
\end{aligned}
\] & \(n s \min\) ns min & Data Valid to Write Setup Time \\
\hline \(t_{6}\)
\[
@_{\mathrm{T}_{\text {min }}} \text { to } \mathrm{T}_{\text {max }}{ }^{\circ}
\] & \[
\begin{aligned}
& 10 \\
& 10
\end{aligned}
\] & \[
\begin{aligned}
& 10 \\
& 10
\end{aligned}
\] & ns min ns \(\min\) & Data Valid to Write Hold Time \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Maximum possible reference voltage.
\({ }^{2}\) Temperature ranges are as follows:
K, L Versions: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
B, C Versions: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
T, U Versions: \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
\({ }^{3}\) Sample Tested at \(25^{\circ} \mathrm{C}\) by Product Assurance to ensure compliance.
\({ }^{4}\) Switching characteristics apply for single and dual supply operation.
Specifications subject to change without notice.

ABSOLUTE MAXIMUM RATINGS*


\section*{NOTES}
\({ }^{1}\) The outputs may be shorted to AGND provided that the power dissipation of the package is not exceeded. Typically short circuit current to AGND is 60 mA .
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ORDERING GUIDE
\begin{tabular}{|c|c|c|c|}
\hline Model \({ }^{1}\) & Temperature Range & Total Unadjusted Error (LSB) & Package Option \({ }^{2}\) \\
\hline AD7224KN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 2\) max & N-18 \\
\hline AD7224LN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1\) max & N-18 \\
\hline AD7224KP & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 2\) max & P-20A \\
\hline AD7224LP & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1\) max & P-20A \\
\hline AD7224KR-1 & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 2\) max & R-20 \\
\hline AD7224LR-1 & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1\) max & R-20 \\
\hline AD7224KR-18 & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 2\) max & R-18 \\
\hline AD7224LR-18 & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1\) max & R-18 \\
\hline AD7224BQ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 2\) max & Q-18 \\
\hline AD7224CQ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1\) max & Q-18 \\
\hline AD7224TQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 2\) max & Q-18 \\
\hline AD7224UQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1\) max & Q-18 \\
\hline AD7224TE & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 2\) max & E-20A \\
\hline AD7224UE & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1\) max & E-20A \\
\hline
\end{tabular}

NOTES
\({ }^{1}\) To order MIL-STD-883 processed parts, add /883B to part number. Contact your local sales office for military data sheet.
\({ }^{2} \mathrm{E}=\) Leadless Ceramic Chip Carrier; \(\mathrm{N}=\) Plastic DIP; \(\mathbf{P}=\) Plastic Leaded; \(\mathbf{Q}=\) Cerdip; \(\mathbf{R}=\) SOIC. For outline information see Package Information section.

\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are removed.


\section*{PIN CONFIGURATIONS}
 LC²MOS Quad 8-Bit DAC

\section*{FEATURES}

\author{
Four 8-Bit DACs with Output Amplifiers Separate Reference Input for Each DAC \(\mu\) P Compatible with Double-Buffered Inputs Simultaneous Update of All Four Outputs Operates with Single or Dual Supplies Extended Temperature Range Operation No User Trims Required \\ Skinny 24-Pin DIP, SOIC and 28-Terminal Surface Mount Packages
}

\section*{GENERAL DESCRIPTION}

The AD7225 contains four 8-bit voltage output digital-to-analog converters, with output buffer amplifiers and interface logic on a single monolithic chip. Each D/A converter has a separate reference input terminal. No external trims are required to achieve full specified performance for the part.
The double-buffered interface logic consists of two 8-bit registers per channel-an input register and a DAC register. Control inputs A0 and A1 determine which input register is loaded when \(\overline{\text { WR }}\) goes low. Only the data held in the DAC registers determines the analog outputs of the converters. The double-buffering allows simultaneous update of all four outputs under control of LDAC. All logic inputs are TTL and CMOS (5V) level compatible and the control logic is speed compatible with most 8 -bit microprocessors.
Specified performance is guaranteed for input reference voltages from +2 V to +12.5 V when using dual supplies. The part is also specified for single supply operation using a reference of +10 V . Each output buffer amplifier is capable of developing +10 V across a \(2 \mathrm{k} \Omega\) load.
The AD7225 is fabricated on an all ion-implanted high-speed Linear Compatible CMOS (LC \({ }^{2}\) MOS) process which has been specifically developed to integrate high-speed digital logic circuits and precision analog circuitry on the same chip.

FUNCTIONAL BLOCK DIAGRAM


\section*{PRODUCT HIGHLIGHTS}
1. DACs and Amplifiers on CMOS Chip

The single-chip design of four 8-bit DACs and amplifiers allows a dramatic reduction in board space requirements and offers increased reliability in systems using multiple converters. Its pinout is aimed at optimizing board layout with all analog inputs and outputs at one end of the package and all digital inputs at the other.
2. Single or Dual Supply Operation The voltage-mode configuration of the AD7225 allows single supply operation. The part can also be operated with dual supplies giving enhanced performance for some parameters.
3. Versatile Interface Logic

The AD7225 has a common 8-bit data bus with individual DAC latches, providing a versatile control architecture for simple interface to microprocessors. The double-buffered interface allows simultaneous update of the four outputs.
4. Separate Reference Input for Each DAC

The AD7225 offers great flexibility in dealing with input signals with a separate reference input provided for each DAC and each reference having variable input voltage capability.

\section*{AD7225—SPECIFICATIONS}

DUAL SUPPLY \(\begin{aligned} & \left(\begin{array}{l}\left(V_{D 0}=11.4 V\right. \\ \text { All specifications } \\ \mathrm{T}_{\text {min }}\end{array} \text { to } \mathrm{T}_{\text {max }} \text { unless otherwise noted. }\right)\end{aligned}\)
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline Parameter & \[
\begin{aligned}
& \text { K, B } \\
& \text { Versions }{ }^{2}
\end{aligned}
\] & \begin{tabular}{l}
L, C \\
Versions \({ }^{2}\)
\end{tabular} & T Version & U Version & Units & Conditions/Comments \\
\hline \multicolumn{7}{|l|}{STATIC PERFORMANCE} \\
\hline Resolution & 8 & 8 & 8 & 8 & Bits & \\
\hline Total Unadjusted Error & \(\pm 2\) & \(\pm 1\) & \(\pm 2\) & \(\pm 1\) & LSB max & \(\mathrm{V}_{\mathrm{DD}}=+15 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\text {REF }}=+10 \mathrm{~V}\) \\
\hline Relative Accuracy & \(\pm 1\) & \(\pm 1 / 2\) & \(\pm 1\) & \(\pm 1 / 2\) & LSB max & \\
\hline Differential Nonlinearity & \(\pm 1\) & \(\pm 1\) & \(\pm 1\) & \(\pm 1\) & LSB max & Guaranteed Monotonic \\
\hline Full Scale Error & \(\pm 1\) & \(\pm 1 / 2\) & \(\pm 1\) & \(\pm 1 / 2\) & LSB max & \\
\hline Full Scale Temp. Coeff. & \(\pm 5\) & \(\pm 5\) & \(\pm 5\) & \(\pm 5\) & ppm \(/{ }^{\circ} \mathrm{C}\) typ & \(\mathrm{V}_{\mathrm{DD}}=14 \mathrm{~V}\) to \(16.5 \mathrm{~V}, \mathrm{~V}_{\text {REF }}=+10 \mathrm{~V}\) \\
\hline Zero Code Error@ \(25^{\circ} \mathrm{C}\) & \(\pm 25\) & \(\pm 15\) & \(\pm 25\) & \(\pm 15\) & mV max & \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & \(\pm 30\) & \(\pm 20\) & \(\pm 30\) & \(\pm 20\) & mV max & \\
\hline Zero Code Error Temp Coeff. & \(\pm 30\) & \(\pm 30\) & \(\pm 30\) & \(\pm 30\) & \(\mu \mathrm{V} /{ }^{\circ} \mathrm{Ctyp}\) & \\
\hline \multicolumn{7}{|l|}{REFERENCEINPUT} \\
\hline Voltage Range & 2 to ( \(\left.\mathrm{V}_{\mathrm{DD}}-4\right)\) & 2 to ( \(\left.\mathrm{V}_{\mathrm{DD}}-4\right)\) & 2 to ( \(\left.\mathrm{V}_{\mathrm{DD}}-4\right)\) & 2 to ( \(\left.\mathrm{V}_{\mathrm{DD}}-4\right)\) & \(\mathrm{V}_{\text {min }}\) to \(\mathrm{V}_{\text {max }}\) & \\
\hline Input Resistance & 11 & 11 & 11 & 11 & \(\mathrm{k} \Omega\) min & \\
\hline Input Capacitance \({ }^{3}\) & 100 & 100 & 100 & 100 & pF max & Occurs when each DAC is loaded with all l's \\
\hline Channel-to-Channel Isolation \({ }^{3}\) & 60 & 60 & 60 & 60 & dB min & \(\mathrm{V}_{\text {REF }}=10 \mathrm{~V}\) p-p Sine Wave @ 10 kHz \\
\hline AC Feedthrough \({ }^{3}\) & -70 & -70 & -70 & -70 & dB max & \(\mathrm{V}_{\text {REF }}=10 \mathrm{~V}\) p-pSine Wave @ 10 kHz \\
\hline \multicolumn{7}{|l|}{DIGITAL INPUTS} \\
\hline Input High Voltage, \(\mathrm{V}_{\text {INH }}\) & 2.4 & 2.4 & 2.4 & 2.4 & \(V\) min & \\
\hline Input Low Voltage, \(\mathrm{V}_{\text {INL }}\) & 0.8 & 0.8 & 0.8 & 0.8 & \(V\) max & \\
\hline Input Leakage Current & \(\pm 1\) & \(\pm 1\) & \(\pm 1\) & \(\pm 1\) & \(\mu \mathrm{A}\) max & \(\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}\) or \(\mathrm{V}_{\mathrm{DD}}\) \\
\hline Input Capacitance \({ }^{3}\) & 8 & 8 & 8 & 8 & pF max & \\
\hline Input Coding & Binary & Binary & Binary & Binary & & \\
\hline \multicolumn{7}{|l|}{DYNAMIC PERFORMANCE} \\
\hline Voltage Output Slew Rate \({ }^{3}\) & 2.5 & 2.5 & 2.5 & 2.5 & V/us min & \\
\hline \multicolumn{7}{|l|}{Voltage Output Settling Time \({ }^{3}\)} \\
\hline Positive Full Scale Change & 5 & 5 & 5 & 5 & \(\mu s\) max & \(\mathrm{V}_{\text {REF }}=+10 \mathrm{~V}\); Settling Time to \(\pm 1 / 2 \mathrm{LSB}\) \\
\hline Negative Full Scale Change & 5 & 5 & 5 & 5 & \(\mu s\) max & \(\mathrm{V}_{\text {REF }}=+10 \mathrm{~V}\); Settling Time to \(\pm 1 / 2 \mathrm{LSB}\) \\
\hline Digital Feedthrough \({ }^{3}\) & 50 & 50 & 50 & 50 & nV secs typ & Code transition all 0's to all l's. \\
\hline Digital Crosstalk \({ }^{3}\) & 50 & 50 & 50 & 50 & nV secs typ & Code transition all 0's to all l's. \\
\hline Minimum Load Resistance & 2 & 2 & 2 & 2 & \(\mathrm{k} \Omega\) min & \(\mathrm{V}_{\text {OUT }}=+10 \mathrm{~V}\) \\
\hline \multicolumn{7}{|l|}{POWER SUPPLIES} \\
\hline \(\mathrm{V}_{\text {DD }}\) Range & 11.4/16.5 & 11.4/16.5 & 11.4/16.5 & 11.4/16.5 & \(\mathrm{V}_{\text {min }} / \mathrm{V}_{\text {max }}\) & For Specified Performance \\
\hline \(\mathrm{I}_{\text {DD }}\) & 10 & 10 & 12 & 12 & \(m A\) max & Outputs Unloaded; \(\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {INL }}\) or \(\mathrm{V}_{\text {INH }}\) \\
\hline Iss & 9 & 9 & 10 & 10 & mA max & Outputs Unloaded; \(\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {INL }}\) or \(\mathrm{V}_{\text {INH }}\) \\
\hline \multicolumn{7}{|l|}{SWITCHING CHARACTERISTICS \({ }^{\mathbf{3 , 4}}\)} \\
\hline \multicolumn{7}{|l|}{\(\mathrm{t}_{1}\)} \\
\hline (a) \(25^{\circ} \mathrm{C}\) & 95 & 95 & 95 & 95 & ns min & Write Pulse Width \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & 120 & 120 & 150 & 150 & ns min & \\
\hline \multicolumn{7}{|l|}{\(\mathrm{t}_{2}\)} \\
\hline @ \(25^{\circ} \mathrm{C}\) & 0 & 0 & 0 & 0 & ns min & Address to Write Setup Time \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & 0 & 0 & 0 & 0 & ns min & \\
\hline \multicolumn{7}{|l|}{\(\mathrm{t}_{3}\)} \\
\hline \(@ 25^{\circ} \mathrm{C}\) & 0 & 0 & 0 & 0 & ns min & Address to Write Hold Time \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & 0 & 0 & 0 & 0 & ns min & \\
\hline \multicolumn{7}{|l|}{\(\mathrm{t}_{4}\)} \\
\hline @ \(25^{\circ} \mathrm{C}\) & 70 & 70 & 70 & 70 & ns min & Data Valid to Write Setup Time \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & 90 & 90 & 90 & 90 & ns min & \\
\hline \multicolumn{7}{|l|}{\(t_{5}\)} \\
\hline @ \(25^{\circ} \mathrm{C}\) & 10 & 10 & 10 & 10 & ns min & Data Valid to Write Hold Time \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & 10 & 10 & 10 & 10 & ns min & \\
\hline \multicolumn{7}{|l|}{\(t_{6}\)} \\
\hline @ \(25^{\circ} \mathrm{C}\) & 95 & 95 & 95 & 95 & ns min & Load DAC Pulse Width \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & 120 & 120 & 150 & 150 & ns min & \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Maximum possible reference voltage.
\({ }^{2}\) Temperature ranges are as follows:
K, L Versions: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
B, C Versions: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
T, U Versions: \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
\({ }^{3}\) Sample Tested at \(25^{\circ} \mathrm{C}\) to ensure compliance.
Switching characteristics apply for single and dual supply operation
Specifications subject to change without notice.

SINGLE SUPPLY \(V_{D D}=+15 V \pm 5 \% ; V_{S S}=A G N D=D G N D=O V ; V_{\text {REF }}=+10 V^{1}\) unless otherwise stated. All specifications \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) unless otherwise noted.)
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline Parameter & \[
\begin{aligned}
& \text { K, B } \\
& \text { Versions }{ }^{2}
\end{aligned}
\] & \[
\begin{aligned}
& \text { L,C } \\
& \text { Versions }{ }^{2}
\end{aligned}
\] & T Version & U Version & Units & Conditions/Comments \\
\hline \multicolumn{7}{|l|}{STATIC PERFORMANCE} \\
\hline Resolution & 8 & 8 & 8 & 8 & Bits & \\
\hline Total Unadjusted Error \({ }^{3}\) & \(\pm 2\) & \(\pm 1\) & \(\pm 2\) & \(\pm 1\) & LSB max & \\
\hline Differential Nonlinearity \({ }^{3}\) & \(\pm 1\) & \(\pm 1\) & \(\pm 1\) & \(\pm 1\) & LSB max & Guaranteed Monotonic \\
\hline \multicolumn{7}{|l|}{REFERENCEINPUT} \\
\hline Input Resistance & 11 & 11 & 11 & 11 & \(\mathrm{k} \Omega\) min & \\
\hline Input Capacitance \({ }^{4}\) & 100 & 100 & 100 & 100 & pF max & Occurs when each DAC is loaded with all 1 \\
\hline Channel-to-Channel Isolation \({ }^{\text {3,4 }}\) & 60 & 60 & 60 & 60 & dB min & \(\mathrm{V}_{\text {REF }}=10 \mathrm{~V}\) p-pSine Wave \({ }_{\text {a }}\) ( 10 kHz \\
\hline AC Feedthrough \({ }^{3,4}\) & -70 & -70 & -70 & -70 & dB max & \(\mathrm{V}_{\text {REF }}=10 \mathrm{~V}\) p-p Sine Wave \((a) 10 \mathrm{kHz}\) \\
\hline \multicolumn{7}{|l|}{DIGITAL INPUTS} \\
\hline Input High Voltage, \(\mathrm{V}_{\text {INH }}\) & 2.4 & 2.4 & 2.4 & 2.4 & \(V_{\text {min }}\) & \\
\hline Input Low Voltage, \(\mathrm{V}_{\text {INL }}\) & 0.8 & 0.8 & 0.8 & 0.8 & \(V\) max & \\
\hline Input Leakage Current & \(\pm 1\) & \(\pm 1\) & \(\pm 1\) & \(\pm 1\) & \(\mu \mathrm{A}\) max & \(\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}\) or \(\mathrm{V}_{\mathrm{DD}}\) \\
\hline Input Capacitance \({ }^{4}\) & 8 & 8 & 9 & 8 & pF max & \\
\hline Input Coding & Binary & Binary & Binary & Binary & & \\
\hline \multicolumn{7}{|l|}{DYNAMIC PERFORMANCE} \\
\hline Voltage Output Slew Rate \({ }^{4}\) & 2 & 2 & 2 & 2 & \(\mathrm{V} / \mathrm{\mu s} \min\) & \\
\hline \multicolumn{7}{|l|}{Voltage Output Settling Time \({ }^{4}\)} \\
\hline Positive Full Scale Change & 5 & 5 & 5 & 5 & \(\mu s\) max & Settling Time to \(\pm 1 / 2 \mathrm{LSB}\) \\
\hline Negative Full Scale Change & 7 & 7 & 7 & 7 & \(\mu \mathrm{s}\) max & Settling Time to \(\pm 1 / 2\) LSB \\
\hline Digital Feedthrough \({ }^{\text {3,4 }}\) & 50 & 50 & 50 & 50 & \(n \mathrm{~V}\) secs typ & Code transition all 0's to all l's. \\
\hline Digital Crosstalk \({ }^{3,4}\) & 50 & 50 & 50 & 50 & nV secs typ & Code transition all 0 's to all l's. \\
\hline Minimum Load Resistance & 2 & 2 & 2 & 2 & \(\mathrm{k} \Omega\) min & \(\mathrm{V}_{\text {OUT }}=+10 \mathrm{~V}\) \\
\hline \multicolumn{7}{|l|}{POWER SUPPLIES} \\
\hline \(\mathrm{V}_{\text {DD }}\) Range & 14.25/15.75 & 14.25/15.75 & 14.25/15.75 & 14.25/15.75 & \(\mathrm{V}_{\text {min }} / \mathrm{V}_{\text {max }}\) & For Specified Performance \\
\hline \(\mathrm{I}_{\mathrm{DD}}\) & 10 & 10 & 12 & 12 & mA max & Outputs Unloaded; \(\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {INL }}\) or \(\mathrm{V}_{\text {INH }}\) \\
\hline \multicolumn{7}{|l|}{SWITCHING CHARACTERISTICS \({ }^{4}\)} \\
\hline \multicolumn{7}{|l|}{\(\mathrm{t}_{1}\)} \\
\hline @ \(25^{\circ} \mathrm{C}\) & 95 & 95 & 95 & 95 & \(n \mathrm{nmin}\) & Write Pulse Width \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & 120 & 120 & 150 & 150 & \(n s\) min & \\
\hline \multicolumn{7}{|l|}{\(\mathrm{t}_{2}\)} \\
\hline @ \(25^{\circ} \mathrm{C}\) & 0 & 0 & 0 & 0 & ns min & Address to Write Setup Time \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & 0 & 0 & 0 & 0 & ns min & \\
\hline \multicolumn{7}{|l|}{\(\mathrm{t}_{3}\)} \\
\hline @ \(25^{\circ} \mathrm{C}\) & 0 & 0 & 0 & 0 & ns min & Address to Write Hold Time \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & 0 & 0 & 0 & 0 & ns min & \\
\hline \multicolumn{7}{|l|}{\({ }_{4}\)} \\
\hline @ \(25^{\circ} \mathrm{C}\) & 70 & 70 & 70 & 70 & ns min & Data Valid to Write Setup Time \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & 90 & 90 & 90 & 90 & ns min & \\
\hline \multicolumn{7}{|l|}{\(t_{5}\)} \\
\hline @ \(25^{\circ} \mathrm{C}\) & 10 & 10 & 10 & 10 & ns min & Data Valid to Write Hold Time \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & 10 & 10 & 10 & 10 & ns min & \\
\hline \multicolumn{7}{|l|}{\(t_{6}\)} \\
\hline @ \(25^{\circ} \mathrm{C}\) & 95 & 95 & 95 & 95 & ns min & Load DAC Pulse Width \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & 120 & 120 & 150 & 150 & ns min & \\
\hline
\end{tabular}

NOTES
\({ }^{1}\) Maximum possible reference voltage.
\({ }^{2}\) Temperature ranges are as follows:
K, L Versions: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
B, C Versions: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
T, U Versions: \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
\({ }^{3}\) Sample Tested at \(25^{\circ} \mathrm{C}\) to ensure compliance
\({ }^{4}\) Switching characteristics apply for single and dual supply operation.
Specifications subject to change without notice.

ORDERING GUIDE
\begin{tabular}{l|l|l|l}
\hline & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Total \\
Unadjusted \\
Error
\end{tabular} & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD7225KN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 2 \mathrm{LSB}\) & \(\mathrm{N}-24\) \\
AD7225LN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1\) LSB & N-24 \\
AD7225KP & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 2\) LSB & P-28A \\
AD7225LP & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1\) LSB & P-28A \\
AD7225KR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 2 \mathrm{LSB}\) & R-24 \\
AD7225LR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1\) LSB & R-24 \\
\hline
\end{tabular}

NOTES
\({ }^{1}\) To order MIL-STD-883 processed parts, add /883B to part number. Contact your local sales office for military data sheet.
\begin{tabular}{l|l|l|l}
\hline & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Total \\
Unadjusted \\
Error
\end{tabular} & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD7225BQ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 2\) LSB & \(\mathrm{Q}-24\) \\
AD7225CQ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1\) LSB & \(\mathrm{Q}-24\) \\
AD7225TQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 2 \mathrm{LSB}\) & \(\mathrm{Q}-24\) \\
AD7225UQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & Q-24 \\
AD7225TE & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 2 \mathrm{LSB}\) & \(\mathrm{E}-28 \mathrm{~A}\) \\
AD7225UE & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\mathrm{E}-28 \mathrm{~A}\) \\
\hline
\end{tabular}
\({ }^{2} \mathrm{E}=\) Leadless Ceramic Chip Carrier; \(\mathbf{N}=\) Plastic DIP; \(\mathbf{P}=\) Plastic Leaded Chip Carrier; \(\mathbf{Q}=\) Cerdip; \(\mathrm{R}=\) SOIC. For outline information see Package Information section.


\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are removed.

Industrial (B, C Versions) . . . . . . . . \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
Extended (T, U Versions) . ... . . . . . \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
Storage Temperature . . . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Lead Temperature (Soldering, 10secs) . . . . . . . . \(+300^{\circ} \mathrm{C}\)
NOTES
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
\({ }^{1}\) Outputs may be shorted to any voltage in the range \(\mathrm{V}_{\mathrm{ss}}\) to \(\mathrm{V}_{\mathrm{DD}}\) provided that the power dissipation of the package is not exceeded. Typical short circuit current for a short to \(A G N D\) or \(V_{\text {ss }}\) is 50 mA .


\section*{TERMINOLOGY}

\section*{TOTAL UNADJUSTED ERROR}

Total Unadjusted Error is a comprehensive specification which includes full scale error, relative accuracy, and zero code error. Maximum output voltage is \(\mathrm{V}_{\text {REF }}\) - 1LSB (ideal), where 1 LSB (ideal) is \(\mathrm{V}_{\mathrm{REF}} / 256\). The LSB size will vary over the \(\mathrm{V}_{\text {REF }}\) range. Hence the zero code error will, relative to the LSB size, increase as \(\mathrm{V}_{\text {REF }}\) decreases. Accordingly, the total unadjusted error, which includes the zero code error, will also vary in terms of LSB's over the \(\mathrm{V}_{\text {REF }}\) range. As a result, total unadjusted error is specified for a fixed reference voltage of +10 V .

\section*{RELATIVE ACCURACY}

Relative Accuracy or end-point nonlinearity is a measure of the maximum deviation from a straight line passing through the end-points of the DAC transfer function. It is measured after allowing for zero code error and full scale error and is normally expressed in LSB's or as a percentage of full scale reading.

\section*{DIFFERENTIAL NONLINEARITY}

Differential Nonlinearity is the difference between the measured change and the ideal 1LSB change between any two adjacent codes. A specified differential nonlinearity of

\(\pm 1\) LSB max over the operating temperature range ensures monotonicity.

\section*{DIGITAL FEEDTHROUGH}

Digital Feedthrough is the glitch impulse transferred to the output of the DAC due to a change in its digital input code. It is specified in nV secs and is measured at \(\mathrm{V}_{\mathrm{REF}}=0 \mathrm{~V}\).

\section*{DIGITAL CROSSTALK}

Digital Crosstalk is the glitch impulse transferred to the output of one converter (not addressed) due to a change in the digital input code to another addressed converter. It is specified in nV secs and is measured at \(\mathrm{V}_{\mathrm{REF}}=0 \mathrm{~V}\).

\section*{AC FEEDTHROUGH}

AC Feedthrough is the proportion of reference input signal which appears at the output of a converter when that DAC is loaded with all 0 's.

\section*{CHANNEL-TO-CHANNEL ISOLATION}

Channel-to-channel isolation is the proportion of input signal from the reference of one DAC (loaded with all l's) which appears at the output of one of the other three DACs (loaded with all 0 's). The figure given is the worst case for the three other outputs and is expressed as a ratio in dBs.

\section*{FULL SCALE ERROR}

Full Scale Error is defined as:
Measured Value - Zero Code Error - Ideal Value

\section*{FEATURES}

\section*{Four 8-Bit DAGs with Output Amplifiers}

Skinny 20-Pin DIP, SOIC and 20-Terminal
Surface Mount Packages
Microprocessor Compatible
TTLCMOS Compatible
No User Trims
Extended Temperature Range Operation
Single Supply Operation Possible

\section*{APPLICATIONS}

\section*{Process Control}

\section*{Automatic Test Equipment}

Automatic Calibration of Large System Parameters, egg., Gain/Offset

\section*{GENERAL DESCRIPTION}

The AD7226 contains four 8-bit voltage-output digital-to-analog converters, with output buffer amplifiers and interface logic on a single monolithic chip. No external trims are required to achieve full specified performance for the part.
Separate on-chip latches are provided for each of the four D/A converters. Data is transferred into one of these data latches through a common 8-bit TTL/CMOS (5V) compatible input port. Control inputs A0 and A1 determine which DAC is loaded when WR goes low. The control logic is speed-compatible with most 8-bit microprocessors.
Each D/A converter includes an output buffer amplifier capable of driving up to 5 mA of output current. The amplifiers' offsets are laser-trimmed during manufacture, thereby eliminating any requirement for offset mulling.
Specified performance is guaranteed for input reference voltages from +2 V to +12.5 V with dual supplies. The part is also specified for single supply operation at a reference of +10 V .
The AD7226 is fabricated in an all ion-implanted high speed Linear Compatible CMOS (LC \({ }^{2}\) MOS) process which has been specifically developed to allow high speed digital logic circuits and precision analog circuits to be integrated on the same chip.

\section*{PRODUCT HIGHLIGHTS}
1. DAC-to-DAC Matching

Since all four DAGs are fabricated on the same chip at the same time, precise matching and tracking between the DACs is inherent.
2. Single Supply Operation

The voltage mode configuration of the DACs allows the AD7226 to be operated from a single power supply rail.
3. Microprocessor Compatibility

The AD7226 has a common 8-bit data bus with individual DAC latches, providing a versatile control architecture for simple interface to microprocessors. All latch enable signals are level triggered.
4. Small Size

Combining four DACs and four op-amps plus interface logic into 20-pin DIP or SOIC or a 20 -terminal surface mount package allows a dramatic reduction in board space requirements and offers increased reliability in systems using multiple converters. Its pinout is aimed at optimizing board layout with all the analog inputs and outputs at one end of the package and all the digital inputs at the other.


\footnotetext{
This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.
}

\section*{AD7226-SPECIFICATIONS}

Dual Supply \({ }^{\left(N_{D 0}=11.4 V\right.}\) to \(16.5 V^{\prime} V_{S S}=-5 V \pm 10 \% ;\) AGND \(=D G N D=O V ; V_{R E}=2 V\) to \(\left(V_{D O}-4 V\right)^{1}\) unless otherwise stated.
Dual Supply all specifications \(\mathrm{T}_{\text {mm }}\) to \(\mathrm{T}_{\text {max }}\) unless otherwise noted.)
\begin{tabular}{|c|c|c|c|}
\hline Parameter & K, B, T Versions \({ }^{\mathbf{2}}\) & Units & Conditions/Comments \\
\hline \multicolumn{4}{|l|}{STATIC PERFORMANCE} \\
\hline Resolution & 8 & Bits & \\
\hline Total Unadjusted Error & \(\pm 2\) & LSB max & \(\mathrm{V}_{\mathrm{DD}}=+15 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\text {REF }}=+10 \mathrm{~V}\) \\
\hline Relative Accuracy & \(\pm 1\) & LSB max & \\
\hline Differential Nonlinearity & \(\pm 1\) & LSB max & Guaranteed Monotonic \\
\hline Full Scale Error & \(\pm 11 / 2\) & LSB max & \\
\hline Full Scale Temperature Coefficient & \(\pm 20\) & ppm/ \({ }^{\circ} \mathrm{C}\) typ & \(\mathrm{V}_{\mathrm{DD}}=14 \mathrm{~V}\) to \(16.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}}=+10 \mathrm{~V}\) \\
\hline Zero Code Error & \(\pm 30\) & mV max & \\
\hline Zero Code Error Temperature Coefficient & \(\pm 50\) & \(\mu \mathrm{V} /{ }^{\circ} \mathrm{Ctyp}\) & \\
\hline \multicolumn{4}{|l|}{REFERENCE INPUT} \\
\hline Voltage Range & 2 to ( \(\left.\mathrm{V}_{\mathrm{DD}}-4\right)\) & \(\mathrm{V}_{\text {MIN }}\) to \(\mathrm{V}_{\text {MAX }}\) & \\
\hline Input Resistance & & \(\mathrm{k} \Omega\) min & \\
\hline Input Capacitance \({ }^{3}\) & \[
\begin{aligned}
& 65 \\
& 300
\end{aligned}
\] & pF min pF max & Occurs when each DAC loaded with all 0 's. Occurs when each DAC loaded with all l's. \\
\hline \multicolumn{4}{|l|}{DIGITAL INPUTS} \\
\hline Input High Voltage, \(\mathrm{V}_{\text {INH }}\) & 2.4 & \(V\) min & \\
\hline Input Low Voltage, \(\mathrm{V}_{\text {INL }}\) & 0.8 & \(V\) max & \\
\hline Input Leakage Current & \(\pm 1\) & \(\mu \mathrm{Amax}\) & \(\mathrm{V}_{\text {IN }}=0 \mathrm{~V}\) or \(\mathrm{V}_{\text {DD }}\) \\
\hline Input Capacitance & 8 & pF max & \\
\hline Input Coding & Binary & & \\
\hline \multicolumn{4}{|l|}{DYNAMIG PERFORMANCE} \\
\hline Voltage Output Slew Rate \({ }^{4}\) & 2.5 & \(\mathrm{V} / \mu \mathrm{smin}\) & \\
\hline \multicolumn{4}{|l|}{Voltage Output Settling Time \({ }^{4}\)} \\
\hline Positive Full Scale Change & 5 & \(\mu s \max ^{\text {max }}\) & \(\mathrm{V}_{\text {REF }}=+10 \mathrm{~V}\); Settling Time to \(\pm 1 / 2 \mathrm{LSB}\) \\
\hline Negative Full Scale Change & 7 & \(\mu s\) max & \(\mathrm{V}_{\mathrm{REF}}=+10 \mathrm{~V}\); Settling Time to \(\pm 1 / 2 \mathrm{LSB}\) \\
\hline Digital Crosstalk & 50 & nV secs typ & \\
\hline Minimum Load Resistance & 2 & \(\mathrm{k} \boldsymbol{\Omega}\) min & \(\mathrm{V}_{\text {OUT }}=+10 \mathrm{~V}\) \\
\hline POWER SUPPLIES & & & \\
\hline \(\mathrm{V}_{\text {DD }}\) Range & 11.4/16.5 & \(\mathrm{V}_{\text {MIN }} / \mathrm{V}_{\text {MAX }}\) & For Specified Performance \\
\hline \(\mathrm{I}_{\mathrm{DD}}\) & 13 & \(m A \max\) & Outputs Unloaded; \(\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {INL }}\) or \(\mathrm{V}_{\text {INH }}\). \\
\hline ISS & 11 & mA max & Outputs Unloaded; \(\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {INLL }}\) or \(\mathrm{V}_{\text {INH }}\). \\
\hline \multicolumn{4}{|l|}{SWITCHING CHARACTERISTICS \({ }^{\text {4,5 }}\)} \\
\hline \multicolumn{4}{|l|}{Address to Write Setup Time, \(\mathrm{t}_{\text {As }}\)} \\
\hline \(@ 25^{\circ} \mathrm{C}\) & 0 & ns min & \\
\hline \(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) & 0 & ns min & \\
\hline Address to Write Hold Time, \(\mathrm{t}_{\mathrm{AH}}\)
\[
@ 25^{\circ} \mathrm{C}
\] & 10 & ns min & \\
\hline \(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) & 10 & ns min & \\
\hline \multicolumn{4}{|l|}{Data Valid to Write Setup Time, \(\mathrm{t}_{\text {DS }}\)} \\
\hline \(@ 25^{\circ} \mathrm{C}\) & 90 & ns min & \\
\hline \(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) & 100 & ns min & \(\cdots\) \\
\hline \multicolumn{4}{|l|}{Data Valid to Write Hold Time, \(\mathrm{t}_{\text {DH }}\)} \\
\hline @ \(25^{\circ} \mathrm{C}\) & 10 & ns min & \\
\hline \(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) & 10 & ns min & \\
\hline \multicolumn{4}{|l|}{Write Pulse Width, \(\mathrm{t}_{\text {WR }}\)} \\
\hline \(@ 25^{\circ} \mathrm{C}\) & 150 & ns min & \\
\hline \(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) & 200 & ns min & \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Maximum possible reference voltage.
\({ }^{2}\) Temperature ranges are as follows:
K Version: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
B Version: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
T Version: \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
\({ }^{3}\) Guaranteed by design. Not production tested.
\({ }^{4}\) Sample Tested at \(25^{\circ} \mathrm{C}\) to ensure compliance.
\({ }^{5}\) Switching Characteristics apply for both single and dual supply operation.
Specifications subject to change without notice.

\begin{tabular}{llll}
\hline Parameter & K, B, T Versions \({ }^{2}\) & Units & Conditions/Comments \\
\hline STATIC PERFORMANCE & & & \\
Resolution & 8 & Bits & \\
Total Unadjusted Error & \(\pm 2\) & LSB max & \\
Differential Nonlinearity & \(\pm 1\) & LSB max & Guaranteed Monotonic \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|}
\hline \multicolumn{4}{|l|}{REFERENCE INPUT} \\
\hline Input Resistance & 2 & \(\mathrm{k} \Omega\) min & \\
\hline \multirow[t]{2}{*}{Input Capacitance \({ }^{3}\)} & 65 & pF min & Occurs when each DAC loaded with all 0's. \\
\hline & 300 & pF max & Occurs when each DAC loaded with all 1's. \\
\hline \multicolumn{4}{|l|}{DIGITAL INPUTS} \\
\hline Input High Voltage, \(\mathrm{V}_{\text {INH }}\) & 2.4 & \(V_{\text {min }}\) & \\
\hline Input Low Voltage, \(\mathrm{V}_{\text {INL }}\) & 0.8 & \(V\) max & \\
\hline Input Leakage Current & \(\pm 1\) & \(\mu \mathrm{A}\) max & \(\mathrm{V}_{\text {IN }}=0 \mathrm{~V}\) or \(\mathrm{V}_{\text {DD }}\) \\
\hline Input Capacitance & 8 & pF max & \\
\hline Input Coding & Binary & & \\
\hline \multicolumn{4}{|l|}{DYNAMIC PERFORMANCE} \\
\hline Voltage Output Slew Rate \({ }^{4}\) & 2 & V/ \(/ \mathrm{s}\) min & \\
\hline \multicolumn{4}{|l|}{Voltage Output Settling Time \({ }^{4}\)} \\
\hline Positive Full Scale Change & 5 & \(\mu s\) max & Settling Time to \(\pm 1 / 2 \mathrm{LSB}\) \\
\hline Negative Full Scale Change & 20 & \(\mu s\) max & Settling Time to \(\pm 1 / 2 \mathrm{LSB}\) \\
\hline Digital Crosstalk & 50 & nV secs typ & \\
\hline Minimum Load Resistance & 2 & \(k \Omega\) min & \(\mathrm{V}_{\text {OUT }}=+10 \mathrm{~V}\) \\
\hline \multicolumn{4}{|l|}{POWER SUPPLIES} \\
\hline \(\mathrm{V}_{\text {DD }}\) Range & 14.25 to 15.75 & \(\mathrm{V}_{\text {MIN }} / \mathrm{V}_{\text {MAX }}\) & For Specified Performance \\
\hline \(\mathrm{I}_{\mathrm{DD}}\) & 13 & mA max & Outputs Unloaded; \(\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {INL }}\) or \(\mathrm{V}_{\text {INH }}\) \\
\hline
\end{tabular}

NOTES
\({ }^{1}\) Maximum possible reference voltage.
\({ }^{2}\) Temperature ranges are as follows:
K Version: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
B Version: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
T Version: \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
\({ }^{3}\) Guaranteed by design. Not production tested.
\({ }^{4}\) Sample Tested at \(25^{\circ} \mathrm{C}\) to ensure compliance.
\({ }^{5}\) Switching Characteristics apply for both single and dual supply operation.
Specifications subject to change without notice.

\section*{ABSOLUTE MAXIMUMRATINGS*}

Industrial (B Version) . . . . . . . . . . \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
Extended (T Version) . . . . . . . \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
Storage Temperature . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Lead Temperature (Soldering, 10secs) . . . . \(+300^{\circ} \mathrm{C}\)
NOTES
'Outputs may be shorted to AGND provided that the power dissipation of the
package is not exceeded. Typically short circuit current to AGND is 60 mA .
*Stresses above those listed under "Absolute Maximum Ratings" may
cause permanent damage to the device. This is a stress rating only and
functional operation of the device at these or any other conditions above
those indicated in the operational sections of this specification is not
implied. Exposure to absolute maximum rating conditions for extended
periods may affect device reliability.

\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are removed.

ORDERING GUIDE
\begin{tabular}{l|l|l|l}
\hline Model \(^{1}\) & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Total \\
Unadjusted \\
Error
\end{tabular} & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD7226KN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 2 \mathrm{LSB}\) & \(\mathrm{N}-20\) \\
AD7226KP & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 2 \mathrm{LSB}\) & P-20A \\
AD7226KR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 2 \mathrm{LSB}\) & R-20 \\
AD7226BQ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 2 \mathrm{LSB}\) & Q-20 \\
AD7226TQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 2 \mathrm{LSB}\) & Q-20 \\
AD7226TE & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 2 \mathrm{LSB}\) & \(\mathrm{E}-20 \mathrm{~A}\) \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) To order MIL-STD-883, Class B processed parts, add /883B to part number. Contact your local sales office for military data sheet. For U.S. Standard Military Drawing (SMD), see DESC drawing \#5962-87802.
\({ }^{2} \mathrm{E}=\) Leadless Ceramic Chip Carrier; N = Plastic DIP; P = Plastic Leaded Chip Carrier; \(\mathrm{Q}=\) Cerdip; \(\mathrm{R}=\) SOIC. For outline information see Package Information section.

\section*{TERMINOLOGY}

\section*{TOTAL UNADJUSTED ERROR}

This is a comprehensive specification which includes full-scale error, relative accuracy and zero code error. Maximum output voltage is \(\mathrm{V}_{\mathrm{REF}}-1\) LSB (ideal), where 1 LSB (ideal) is \(\mathrm{V}_{\text {REF }} / 256\). The LSB size will vary over the \(\mathrm{V}_{\text {REF }}\) range. Hence the zero code error will, relative to the LSB size, increase as \(\mathrm{V}_{\text {REF }}\) decreases. Accordingly, the total unadjusted error, which includes the zero code error, will also vary in terms of LSB's over the \(\mathrm{V}_{\text {REF }}\) range. As a result, total unadjusted error is specified for a fixed reference voltage of +10 V .

\section*{RELATIVE ACCURACY}

Relative Accuracy or end-point nonlinearity, is a measure of the maximum deviation from a straight line passing through the end-points of the DAC transfer function. It is measured after allowing for zero and full-scale error and is normally expressed in LSB's or as a percentage of full-scale reading.

\section*{DIFFERENTIAL NONLINEARITY}

Differential Nonlinearity is the difference between the measured change and the ideal 1LSB change between any two adjacent codes. A specified differential nonlinearity of \(\pm 1\) LSB max over the operating temperature range ensures monotonicity.

\section*{DIGITAL CROSSTALK}

The glitch impulse transferred to the output of one converter due to a change in the digital input code to another of the converters. It is specified in nV secs and is measured at \(\mathrm{V}_{\mathrm{REF}}=0 \mathrm{~V}\).

\section*{FULL-SCALE ERROR}

Full-Scale Error is defined as:
Measured Value - Zero Code Error - Ideal Value.

\section*{PIN CONFIGURATIONS}


LCCC



FEATURES
Eight 8-Bit DACs with Output Amplifiers
Operates with Single or Dual Supplies
\(\boldsymbol{\mu P}\) Compatible (95ns WR Pulse)
No User Trims Required
Skinny 24-Pin DIPs, SOIC, and 28 -Terminal Surface
Mount Packages

\section*{GENERAL DESCRIPTION}

The AD7228A contains eight 8-bit voltage-mode digital-to-analog converters, with output buffer amplifiers and interface logic on a single monolithic chip. No external trims are required to achieve full specified performance for the part.
Separate on-chip latches are provided for each of the eight D/A converters. Data is transferred into the data latches through a common 8 -bit TTL/CMOS ( 5 V ) compatible input port. Address inputs A0, A1 and A2 determine which latch is loaded when WR goes low. The control logic is speed compatible with most 8 -bit microprocessors.

Specified performance is guaranteed for input reference voltages from +2 to +10 V when using dual supplies. The part is also specified for single supply +15 V operation using a reference of +10 V and single supply +5 V operation using a reference of +1.23 V . Each output buffer amplifier is capable of developing +10 V across a \(2 \mathrm{k} \Omega\) load.

The AD7228A is fabricated on an all ion-implanted, high-speed, Linear Compatible CMOS (LC \({ }^{2}\) MOS) process which has been specifically developed to integrate high-speed digital logic circuits and precision analog circuits on the same chip.

FUNCTIONAL BLOCK DIAGRAM


\section*{PRODUCT HIGHLIGHTS}
1. Eight DACs and Amplifiers in Small Package

The single-chip design of eight 8-bit DACs and amplifiers allows a dramatic reduction in board space requirements and offers increased reliability in systems using multiple converters. Its pinout is aimed at optimizing board layout with all analog inputs and outputs at one side of the package and all digital inputs at the other.
2. Single or Dual Supply Operation

The voltage-mode configuration of the DACs allows single supply operation of the AD7228A. The part can also be operated with dual supplies giving enhanced performance for some parameters.
3. Microprocessor Compatibility

The AD7228A has a common 8-bit data bus with individual DAC latches, providing a versatile control architecture for simple interface to microprocessors. All latch enable signals are level triggered and speed compatible with most highperformance 8-bit microprocessors.

This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

\section*{AD7228A - SPECIFICATIONS}

\begin{tabular}{|c|c|c|c|c|c|c|}
\hline Parameter & \begin{tabular}{l}
AB \\
Version \({ }^{2}\)
\end{tabular} & \begin{tabular}{l}
AC \\
Version
\end{tabular} & \begin{tabular}{l}
AT \\
Version
\end{tabular} & \begin{tabular}{l}
AU \\
Version
\end{tabular} & Units & Conditions/Comments \\
\hline \multicolumn{7}{|l|}{STATIC PERFORMANCE} \\
\hline Resolution & 8 & 8 & 8 & 8 & Bits & \\
\hline Total Unadjusted Error \({ }^{3}\) & \(\pm 2\) & \(\pm 1\) & \(\pm 2\) & \(\pm 1\) & LSB max & \(\mathrm{V}_{\mathrm{DD}}=+15 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{\text {REF }}=+10 \mathrm{~V}\) \\
\hline Relative Accuracy & \(\pm 1\) & \(\pm 1 / 2\) & \(\pm 1\) & \(\pm 1 / 2\) & LSB max & \\
\hline Differential Nonlinearity & \(\pm 1\) & \(\pm 1\) & \(\pm 1\) & \(\pm 1\) & LSB max & Guaranteed Monotonic \\
\hline Full-Scale Error \({ }^{4}\) & \(\pm 1\) & \(\pm 1 / 2\) & \(\pm 1\) & \(\pm 1 / 2\) & LSB max & Typical tempco is \(5 \mathrm{ppm} /{ }^{\circ} \mathrm{C}\) with \(\mathrm{V}_{\text {REF }}=+10 \mathrm{~V}\) \\
\hline Zero Code Error & & & & & & \\
\hline @ \(25^{\circ} \mathrm{C}\) & \(\pm 25\) & \(\pm 15\) & \(\pm 25\) & \(\pm 15\) & mV max & Typical tempco is \(30 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}\) \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & \(\pm 30\) & \(\pm 20\) & \(\pm 30\) & \(\pm 20\) & mV max & \\
\hline Minimum Load Resistance & 2 & 2 & 2 & 2 & \(\mathrm{k} \Omega\) min & \(\mathrm{V}_{\text {OUT }}=+10 \mathrm{~V}\) \\
\hline \multicolumn{7}{|l|}{REFERENCE INPUT} \\
\hline Voltage Range \({ }^{1}\) & 2 to 10 & 2 to 10 & 2 to 10 & 2 to 10 & \(\mathrm{V}_{\text {min }}\) to \(\mathrm{V}_{\text {max }}\) & \\
\hline Input Resistance & 2 & 2 & & & \(\mathrm{k} \Omega\) min & \\
\hline Input Capacitance5 & 500 & 500 & 500 & 500 & pF max & Occurs when each DAC is loaded with all 1 s . \\
\hline AC Feedthrough & -70 & -70 & -70 & -70 & dB typ & \(\mathrm{V}_{\text {REF }}=8 \mathrm{~V}\) p-p Sine Wave @ 10kHz/ \\
\hline \multicolumn{7}{|l|}{DIGITAL INPUTS} \\
\hline Input High Voltage, \(\mathrm{V}_{\text {INH }}\) & 2.4 & 2.4 & 2.4 & 2.4 & \(V_{\text {min }}\) & \\
\hline Input Low Voltage, \(\mathrm{V}_{\text {INL }}\) & 0.8 & 0.8 & 0.8 & 0.8 & \(V_{\text {max }}\) & \\
\hline Input Leakage Current & \(\pm 1\) & \(\pm 1\) & \(\pm 1\) & \(\pm 1\) & \(\mu \mathrm{A}\) max & \(\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}\) or \(\mathrm{V}_{\text {DD }}\) \\
\hline Input Capacitance \({ }^{5}\) & & 8 & 8 & & pF max & \\
\hline Input Coding & Binary & Binary & Binary & Binary & & \\
\hline \multicolumn{7}{|l|}{DYNAMIC PERFORMANCE \({ }^{5}\)} \\
\hline Voltage Output Slew Rate & 2 & 2 & 2 & 2 & \(\mathrm{V} / \mathrm{\mu s}\) min & \\
\hline Voltage Output Settling Time & & & & & & \\
\hline Positive Full-Scale Change & 5 & 5 & 5 & 5 & \(\mu s\) max & \(\mathrm{V}_{\text {REF }}=+10 \mathrm{~V}\); Settling Time to \(\pm 1 / 2 \mathrm{LSB}\) \\
\hline Negative Full-Scale Change & 5 & 5 & 5 & 5 & \(\mu \mathrm{s}\) max & \(\mathrm{V}_{\text {REF }}=+10 \mathrm{~V}\); Settling Time to \(\pm 1 / 2 \mathrm{LSB}\) \\
\hline Digital Feedthrough & 50 & 50 & 50 & 50 & nV secs typ & Code transition all 0s to all 1 s . \(\mathrm{V}_{\text {REF }}=0 \mathrm{~V}\); \(\overline{\mathrm{WR}}=\mathrm{V}_{\mathrm{DD}}\) \\
\hline Digital Crosstalk \({ }^{6}\) & 50 & 50 & 50 & 50 & nVsecstyp & Code transition all 0 s to all 1s. \(\mathrm{V}_{\text {REF }}=+10 \mathrm{~V} ; \overline{\mathrm{WR}}=0 \mathrm{~V}\) \\
\hline \multicolumn{7}{|l|}{POWER SUPPLIES} \\
\hline \(V_{\text {DD }}\) Range & 10.8/16.5 & 10.8/16.5 & 10.8/16.5 & 10.8/16.5 & \(\mathrm{V}_{\text {min }} / \mathrm{V}_{\text {max }}\) & For Specified Performance \\
\hline \(V_{\text {ss }}\) Range & -4.5/-5.5 & \(-4.5 /-5.5\) & -4.5/-5.5 & -4.5/-5.5 & \(\mathbf{V}_{\text {min }} / \mathbf{V}_{\text {max }}\) & For Specified Performance \\
\hline \(\mathrm{I}_{\text {DD }}\) & & & & & & Outputs Unloaded; \(\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {INL }}\) or \(\mathrm{V}_{\text {INH }}\) \\
\hline @ \(25^{\circ} \mathrm{C}\) & 16 & 16 & 16 & 16 & mA max & \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & 20 & 20 & 22 & 22 & mA max & \\
\hline \(\mathrm{I}_{\text {ss }}\) & & & & & & Outputs Unloaded; \(\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {INL }}\) or \(\mathrm{V}_{\mathrm{INH}}\) \\
\hline \(@ 25^{\circ} \mathrm{C}\) & 14 & 14 & 14 & 14 & mA max & \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & 18 & 18 & 20 & 20 & mA max & \\
\hline
\end{tabular}

SINGLE SUPPLY \(7{ }^{\left(V_{D 0}=+15 V\right.} \pm 10 \%, V_{S S}=G N D=O N ; V_{R E}=+10 V ; R_{L}=2 k \Omega, C_{L}=100 p F\) unless otherwise stated.) \({ }^{\text {Ill }}\) specifications \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) unless otherwise noted.


NOTES
\({ }^{1} \mathbf{V}_{\text {Out }}\) must be less than \(V_{D D}\) by 3.5 V to ensure correct operation.
\({ }^{2}\) Temperature ranges are as follows:
\(\mathrm{AB}, \mathrm{C}\) Versions; \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
AT, U Versions; \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
\({ }^{3}\) Total Unadjusted Error includes zero code error, relative accuracy and full-scale error.
\({ }^{4}\) Calculated after zero code error has been adjusted out.
\({ }^{5}\) Sample tested at \(25^{\circ} \mathrm{C}\) to ensure compliance.
\({ }^{6}\) The glitch impulse transferred to the output of one converter (not addressed)
due to a change in the digital input code to another addressed converter.
\({ }^{7}\) Single +5 V operation is also possible with degraded performance (see Figure 14). Specifications subject to change without notice.

\begin{tabular}{|c|c|c|c|c|c|c|}
\hline Parameter & AD7228AB & AD7228AC & AD7228AT & AD7228AU & Units & Conditions/Comments \\
\hline \begin{tabular}{l}
STATIC PERFORMANCE \\
Resolution
\end{tabular} & 8 & 8 & 8 & 8 & Bits & \\
\hline Relative Accuracy & \(\pm 2\) & \(\pm 2\) & \(\pm 2\) & \(\pm 2\) & LSB max & \\
\hline Differential Nonlinearity & \(\pm 1\) & \(\pm 1\) & \(\pm 1\) & \(\pm 1\) & LSB max & Guaranteed Monotonic \\
\hline Full-Scale Error & \(\pm 4\) & \(\pm 2\) & \(\pm 4\) & \(\pm 2\) & LSB max & \\
\hline \begin{tabular}{l}
Zero Code Error @ \(25^{\circ} \mathrm{C}\) \\
\(T_{\text {min }}\) to \(T_{\text {max }}\)
\end{tabular} & \[
\begin{aligned}
& \pm 30 \\
& \pm 40
\end{aligned}
\] & \[
\begin{aligned}
& \pm 20 \\
& \pm 30
\end{aligned}
\] & \[
\begin{aligned}
& \pm 30 \\
& \pm 40
\end{aligned}
\] & \[
\begin{aligned}
& \pm 20 \\
& \pm \mathbf{3 0}
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{mV} \text { max } \\
& \mathrm{mV} \text { max }
\end{aligned}
\] & \\
\hline \multicolumn{7}{|l|}{REFERENCEINPUT} \\
\hline \multirow[t]{2}{*}{Reference Input Range} & 1.2 & 1.2 & 1.2 & 1.2 & V min & \\
\hline & 1.3 & 1.3 & 1.3 & 1.3 & \(V_{\text {max }}\) & \\
\hline Reference Input Resistance & 2 & 2 & 2 & 2 & \(\mathrm{k} \Omega\) min & \\
\hline Reference Input Capacitance & 500 & 500 & 500 & 500 & pF max & \\
\hline \multicolumn{7}{|l|}{POWER REQUIREMENTS} \\
\hline Positive Supply Range & 4.75/5.25 & 4.75/5.25 & 4.75/5.25 & 4.75/5.25 & \(V_{\text {min }} / V_{\text {max }}\) & For Specified Performance \\
\hline \multicolumn{6}{|l|}{Positive Supply Current} & \\
\hline @ \(25^{\circ} \mathrm{C}\) & 16 & 16 & 16 & 16 & \(\mu \mathrm{A}\) max & \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & 20 & 20 & 22 & 22 & \(\mu \mathrm{A}\) max & \\
\hline \begin{tabular}{l}
Negative Supply Current \\
@ \(25^{\circ} \mathrm{C}\)
\end{tabular} & 14 & 14 & 14 & 14 & \(\mu \mathrm{A}\) max & \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & 18 & 18 & 20 & 20 & \(\mu \mathrm{A}\) max & \\
\hline
\end{tabular}

NOTES
All other specifications as per Dual Supply Specifications except for negative full-scale setting-time when \(\mathbf{V}_{\mathbf{s s}}=\mathbf{0 V}\).
Specifications subject to change without notice.

\section*{SWITCHING CHARACTERISTICS \({ }^{1,2}{ }_{(S e e}\) Figures 1,\(2 ; \mathrm{V}_{D 0}=+5 \mathrm{~V} \pm 5 \%\) or +10.8 V to \(+16.5 \mathrm{~V} ; \mathrm{V}_{\mathrm{SS}}=\mathrm{VV}\) or \(-5 \mathrm{~V} \pm 10 \%\) )}
\begin{tabular}{|c|c|c|c|c|c|}
\hline Parameters & \[
\begin{aligned}
& \text { Limit at } 25^{\circ} \mathrm{C} \\
& \text { All Grades }
\end{aligned}
\] & \(\underset{\text { (K, L, B }, \text { C Grades) }}{\text { Limit at } T_{\text {min }}, T_{\text {max }}}\) (K, L, B, C Grades) & \[
\underset{\text { (T, UGrades) }}{\text { Limit at }_{\text {Timax }}}
\] & Units & Conditions/Comments \\
\hline \(\mathrm{t}_{1}\) & 0 & 0 & 0 & ns min & Address to \(\overline{\overline{W R}}\) Setup Time \\
\hline \(\mathrm{t}_{2}\) & 0 & 0 & 0 & ns min & Address to WR Hold Time \\
\hline \(t_{3}\) & 70 & 90 & 100 & ns min & Data Valid to \(\overline{W R}\) Setup Time \\
\hline \(\mathrm{t}_{4}\) & 10 & 10 & 10 & ns min & Data Valid to WR Hold Time \\
\hline ts & 95 & 120 & 150 & ns min & Write Pulse Width \\
\hline
\end{tabular}

NOTES
\({ }^{1}\) Sample tested at \(25^{\circ} \mathrm{C}\) to ensure compliance. All input rise and fall times measured from \(10 \%\) to \(90 \%\) of \(+5 \mathrm{~V}, \mathrm{t}_{\mathrm{R}}=\mathrm{t}_{\mathrm{F}}=5 \mathrm{~ns}\).
\({ }^{2}\) Timing measurement reference level is \(\frac{\mathrm{V}_{\mathrm{INH}}+\mathrm{V}_{\mathrm{INL}}}{2}\)

\section*{INTERFACE LOGIC INFORMATION}

Address lines A0, A1 and A2 select which DAC accepts data from the input port. Table I shows the selection table for the eight DACs with Figure 1 showing the input control logic. When the \(\overline{\mathrm{WR}}\) signal is low, the input latch of the selected DAC is transparent, and its output responds to activity on the data bus. The data is latched into the addressed DAC latch on the rising edge of \(\overline{\mathbf{W} R}\). While \(\overline{\mathrm{WR}}\) is high, the analog outputs remain at the value corresponding to the data held in their respective latches.
\begin{tabular}{llll|l}
\multicolumn{4}{l|}{ AD7228A Control Inputs } & AD7228A \\
WR & A2 & A1 & A0 & Operation \\
\hline H & X & X & X & \begin{tabular}{l} 
No Operation \\
Device Not Selected
\end{tabular} \\
L & L & L & L & DAC 1 Transparent \\
S & L & L & L & DAC 1 Latched \\
L & L & L & H & DAC 2 Transparent \\
L & L & H & L & DAC 3 Transparent \\
L & L & H & H & DAC 4 Transparent \\
L & H & L & L & DAC 5 Transparent \\
L & H & L & H & DAC 6 Transparent \\
L & H & H & L & DAC 7 Transparent \\
L & H & H & H & DAC 8 Transparent \\
\hline H= High State & L= Low State & X= Don't Care
\end{tabular}

Table I. AD7228A Truth Table


Figure 1. Input Control Logic


NOTE:
THE SELECTED INPUT LATCH IS TRANSPARENT WHILE WR IS LOW.
THUS INVALID DATA DURING THIS TIME CAN CAUSE SPURIOUS OUTPUTS
Figure 2. Write Cycle Timing Diagram


Storage Temperature ........... \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Lead Temperature (Soldering, 10secs) \(\ldots \ldots . .+300^{\circ} \mathrm{C}\)
Lead Temperature (Soldering, 10secs) . ........ . \(+300^{\circ} \mathrm{C}\)

\section*{NOTE}
\({ }^{1}\) Outputs may be shorted to any voltage in the range \(\mathrm{V}_{\text {ss }}\) to \(\mathrm{V}_{\mathrm{DD}}\) provided that the power dissipation of the package is not exceeded. Typical short circuit current for a short to GND or \(\mathrm{V}_{\text {ss }}\) is 50 mA .
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

\section*{CAUTION:}

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are inserted.

\section*{WARNING!} जीता⿵冂1 1

ESD SENSITIVE DEVICE

PIN CONFIGURATIONS


NC = NO CONNECT

\section*{ORDERING GUIDE}
\begin{tabular}{|c|c|c|c|}
\hline Model \({ }^{1}\) & Temperature Range & \begin{tabular}{l}
Total \\
Unadjusted \\
Error (LSB)
\end{tabular} & Package Option \({ }^{2}\) \\
\hline AD7228ABN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 2\) max & N-24 \\
\hline AD7228ACN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1\) max & N-24 \\
\hline AD7228ABP & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 2\) max & P-28A \\
\hline AD7228ACP & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1\) max & P-28A \\
\hline AD7228ABR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 2\) max & R-24 \\
\hline AD7228ACR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1\) max & R-24 \\
\hline AD7228ABQ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 2\) max & Q-24 \\
\hline AD7228ACQ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1\) max & Q-24 \\
\hline AD7228ATQ \({ }^{3}\) & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 2\) max & Q-24 \\
\hline AD7228AUQ \({ }^{3}\) & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1\) max & Q-24 \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) To order MIL-STD-883, Class B processed parts, add /883B to part number. Contact your local sales office for military data sheet and availability.
\({ }^{2} \mathrm{~N}=\) Plastic DIP; \(\mathbf{P}=\) Plastic Leaded Chip Carrier (PLCC);
Q = Cerdip; \(\mathbf{R}=\) Small Outline IC (SOIC). For outline information see
Package Information section.
\({ }^{3}\) These grades will be available to \(/ 883 \mathrm{~B}\) processing only.

\section*{FEATURES}

12-Bit CMOS DAC with
On-Chip Voltage Reference
Output Amplifier
-5 V to +5 V Output Range

\section*{Serial Interface}

300 kHz DAC Update Rate
Small Size : 8-Pin Mini-DIP
Nonlinearity : \(\pm 1 / 2\) LSB \(T_{\text {min }}\) to \(T_{\text {max }}\)
Low Power Dissipation: 100 mW typical

\section*{APPLICATIONS}

Process Control Industrial Automation Digital Signal Processing Systems Input/Output Ports

\section*{GENERAL DESCRIPTION}

The AD7233 is a complete 12 -bit, voltage-output, digital-toanalog converter with output amplifier and Zener voltage reference all in an 8 -pin package. No external trims are required to achieve full specified performance. The data format is 2 s complement, and the output range is -5 V to +5 V .
The AD7233 features a fast, versatile serial interface which allows easy connection to both microcomputers and 16 -bit digital signal processors with serial ports. When the \(\overline{\text { SYNC }}\) input is taken low, data on the SDIN pin is clocked into the input shift register on each falling edge of SCLK. On completion of the 16-bit data transfer, bringing \(\overline{\text { LDAC }}\) low updates the DAC latch with the lower 12 bits of data and updates the output. Alternatively, \(\overline{\text { LDAC }}\) can be tied permanently low, and in this case the DAC register is automatically updated with the contents of the shift register when all sixteen data bits have been clocked in. The serial data may be applied at rates up to 5 MHz allowing a DAC update rate of 300 kHz .

For applications which require greater flexibility and unipolar output ranges with single supply operation, please refer to the AD7243 data sheet.

The AD7233 is fabricated on Linear Compatible CMOS ( \(L^{2}\) MOS), an advanced, mixed-technology process. It is packaged in an 8-pin DIP package.

DACPORT is a registered trademark of Analog Devices, Inc.

FUNCTIONAL BLOCK DIAGRAM

\section*{PRODUCT HIGHLIGHTS}
1. Complete 12 -Bit DACPORT \({ }^{\text {® }}\)
2. The AD7233 is a complete, voltage output, 12 -bit DAC on a single chip. This single-chip design is inherently more reliable than multichip designs.
3. Simple 3-Wire Interface to Most Microcontrollers and DSP Processors.
4. DAC Update Rate-300 kHz.
5. Space Saving 8-Pin Package.


This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

\begin{tabular}{|c|c|c|c|c|}
\hline Parameter & A & B & Units & Test Conditions/Comments \\
\hline \begin{tabular}{l}
STATIC PERFORMANCE \\
Resolution \\
Relative Accuracy \({ }^{3}\) \\
Differential Nonlinearity \({ }^{3}\) \\
Bipolar Zero Error \({ }^{3}\) \\
Full-Scale Error \({ }^{3}\) \\
Full-Scale Temperature Coefficient
\end{tabular} & \[
\begin{aligned}
& 12 \\
& \pm 1 \\
& \pm 0.9 \\
& \pm 6 \\
& \pm 8 \\
& \pm 30
\end{aligned}
\] & \[
\begin{aligned}
& 12 \\
& \pm 1 / 2 \\
& \pm 0.9 \\
& \pm 6 \\
& \pm 8 \\
& \pm 30
\end{aligned}
\] & \begin{tabular}{l}
Bits \\
LSB max \\
LSB max \\
LSB max \\
LSB max \\
ppm of FSR \(/{ }^{\circ} \mathrm{C}\) typ
\end{tabular} & \begin{tabular}{l}
Guaranteed Monotonic \\
DAC Latch Contents 000000000000
\end{tabular} \\
\hline \begin{tabular}{l}
DIGITAL INPUTS \\
Input High Voltage, \(\mathrm{V}_{\text {INH }}\) Input Low Voltage, \(\mathrm{V}_{\text {INL }}\) Input Current \(\mathrm{I}_{\mathrm{IN}}\) Input Capacitance \({ }^{4}\)
\end{tabular} & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 1 \\
& 8
\end{aligned}
\] & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 1 \\
& 8
\end{aligned}
\] & \begin{tabular}{l}
\(V\) min \\
V max \\
\(\mu \mathrm{A}\) max \\
pF max
\end{tabular} & \(\mathrm{V}_{\text {IN }}=0 \mathrm{~V}\) to \(\mathrm{V}_{\mathrm{DD}}\) \\
\hline ANALOG OUTPUTS Output Voltage Range DC Output Impedance & \[
\begin{aligned}
& \pm 5 \\
& 0.5
\end{aligned}
\] & \[
\begin{aligned}
& \pm 5 \\
& 0.5
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{V} \\
& \Omega \text { typ }
\end{aligned}
\] & \(\therefore\) \\
\hline \begin{tabular}{l}
AC CHARACTERISTICS \({ }^{4}\) \\
Voltage Output Settling Time \\
Positive Full-Scale Change \\
Negative Full-Scale Change \\
Digital-to-Analog Glitch Impulse \({ }^{3}\) \\
Digital Feedthrough \({ }^{3}\)
\end{tabular} & \[
\begin{aligned}
& 10 \\
& 10 \\
& 30 \\
& 10
\end{aligned}
\] & \[
\begin{aligned}
& 10 \\
& 10 \\
& 30 \\
& 10
\end{aligned}
\] & \begin{tabular}{l}
\(\mu_{s}\) max \\
\(\mu \mathrm{S}\) max \\
nV secs typ \\
nV secs typ
\end{tabular} & \begin{tabular}{l}
Settling Time to Within \(\pm 1 / 2\) LSB of Final Value \\
Typically \(3 \mu\) s; DAC Latch 100. . . 000 to 011. . . 111 \\
Typically \(5 \mu \mathrm{~s}\); DAC Latch 011 . . . 111 to 100. . . 000 \\
DAC Latch Contents Toggled Between All Os and all 1s
\[
\overline{\text { LDAC }}=\mathrm{High}
\]
\end{tabular} \\
\hline \begin{tabular}{l}
POWER REQUIREMENTS \\
\(V_{\text {DD }}\) Range \\
\(V_{\text {ss }}\) Range \\
\(\mathrm{I}_{\mathrm{DD}}\) \\
\(I_{s s}\)
\end{tabular} & \[
\begin{aligned}
& +10.8 /+16.5 \\
& -10.8 /-16.5 \\
& 10 \\
& 4
\end{aligned}
\] & \[
\begin{aligned}
& +11.4 /+15.75 \\
& -11.4 /-15.75 \\
& 10 \\
& 4
\end{aligned}
\] & \(V \min / V \max\) \(\mathrm{V} \min / \mathrm{V}_{\max }\) mA max mA max & For Specified Performance Unless Otherwise Stated For Specified Performance Unless Otherwise Stated Output Unloaded; Typically 7 mA Output Unloaded; Typically 2 mA \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Temperature Ranges are as follows: A, B Versions: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\).
\({ }^{2}\) Power Supply Tolerance: A Version: \(\pm 10 \%\); B Version: \(\pm 5 \%\).
\({ }^{3}\) See Terminology.
\({ }^{4}\) Sample tested @ \(25^{\circ} \mathrm{C}\) to ensure compliance.
Specifications subject to change without notice.


Figure 3. AD7233 Timing Diagram

\begin{tabular}{|c|c|c|c|c|}
\hline Parameter & Limit at \(25^{\circ} \mathrm{C}\) (All Versions) & Limit at \(\mathbf{T}_{\text {min }}, \mathbf{T}_{\text {max }}\) (All Versions) & Units & Conditions/Comments \\
\hline \(\mathrm{t}_{1}{ }^{3}\) & 200 & 200 & ns min & SCLK Cycle Time \\
\hline \(\mathrm{t}_{2}\) & 50 & 50 & ns min & SYNC to SCLK Falling Edge Setup Time \\
\hline \(\mathrm{t}_{3}\) & 120 & 190 & ns min & SYNC to SCLK Hold Time \\
\hline \(\mathrm{t}_{4}\) & 10 & 10 & ns min & Data Setup Time \\
\hline \(\mathrm{t}_{5}\) & 100 & 100 & ns \(\min\) & Data Hold Time \\
\hline \(\mathrm{t}_{6}\) & 0 & 0 & ns min & SYNC High to \(\overline{\text { LDAC }}\) Low \\
\hline \(\mathrm{t}_{7}\) & 50 & 50 & ns min & LDAC Pulse Width \\
\hline \(\mathrm{t}_{8}\) & 0 & 0 & ns min & LDAC High to SYNC Low \\
\hline
\end{tabular}

NOTES
\({ }^{1}\) Sample tested at \(25^{\circ} \mathrm{C}\) to ensure compliance. All input signals are specified with \(\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%\) to \(90 \%\) of 5 V\()\) and timed from a voltage level of 1.6 V .
\({ }^{2}\) See Figure 3.
\({ }^{3}\) SCLK Mark/Space Ratio range is \(40 / 60\) to \(60 / 40\).

\section*{ABSOLUTE MAXIMUM RATINGS*}
( \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) unless otherwise noted)
\(\mathrm{V}_{\mathrm{DD}}\) to GND . . . . . . . . . . . . . . . . . . . . -0.3 V to +17 V
\(\mathrm{V}_{\mathrm{SS}}\) to GND . . . . . . . . . . . . . . . . . . . . . +0.3 V to -17 V
\(\mathrm{V}_{\text {OUT }}{ }^{1}\) to GND . . . . . . . . . . . . . . . . -6 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
Digital Inputs to GND . . . . . . . . . -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
Operating Temperature Range
Industrial (A, B Versions) . . . . . . . . . . . . \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
Storage Temperature Range . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Lead Temperature (Soldering, 10 secs) . . . . . . . . . . . \(+300^{\circ} \mathrm{C}\)
Power Dissipation to \(+75^{\circ} \mathrm{C}\). . . . . . . . . . . . . . . . . 450 mW
Derates above \(+75^{\circ} \mathrm{C}\) by . . . . . . . . . . . . . . . . . \(10 \mathrm{~mW} /{ }^{\circ} \mathrm{C}\)

NOTE
\({ }^{1}\) The output may be shorted to voltages in this range provided the power dissipation of the package is not exceeded. Short circuit current is typically 80 mA .
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are inserted.


\section*{TERMINOLOGY}

\section*{RELATIVE ACCURACY (LINEARITY)}

Relative accuracy, or endpoint linearity, is a measure of the maximum deviation of the DAC transfer function from a straight line passing through the endpoints of the transfer function. It is measured after allowing for zero and full-scale errors and is expressed in LSBs or as a percentage of full-scale reading.

\section*{DIFFERENTIAL NONLINEARITY}

Differential nonlinearity is the difference between the measured change and the ideal 1 LSB change between any two adjacent codes. A specified differential nonlinearity of \(\pm 1\) LSB or less over the operating temperature range ensures monotonicity.

\section*{BIPOLAR ZERO ERROR}

Bipolar zero error is the voltage measured at \(\mathrm{V}_{\text {OUT }}\) when the DAC is loaded with all 0 s . It is due to a combination of offset errors in the DAC, amplifier and mismatch between the internal gain resistors around the amplifier.

\section*{FULL-SCALE ERROR}

Full-scale error is a measure of the output error when the amplifier output is at full scale (full scale is either positive or negative full scale).

\section*{DIGITAL-TO-ANALOG GLITCH IMPULSE}

This is the voltage spike that appears at the output of the DAC when the digital code in the DAC latch changes before the output settles to its final value. The energy in the glitch is specified in nV secs, and is measured for an all codes change ( 00000000 0000 to 11111111 1111).

\section*{DIGITAL FEEDTHROUGH}

This is a measure of the voltage spike that appears on \(\mathrm{V}_{\text {OUT }}\) as a result of feedthrough from the digital inputs on the AD7233. It is measured with \(\overline{\mathrm{LDAC}}\) held high.

PIN FUNCTION DESCRIPTION
\begin{tabular}{l|l|l}
\hline Pin & Mnemonic & Description \\
\hline 1 & V \(_{\text {DD }}\) & Positive Supply (+12 V to \(+15 \mathrm{~V})\). \\
2 & SCLK & Serial Clock, Logic Input. Data is clocked into the input register on each falling SCLK edge. \\
3 & SDIN & \begin{tabular}{l} 
Serial Data In, Logic Input. The 16-bit serial data word is applied to this input. \\
4
\end{tabular} \\
\hline SYNC & \begin{tabular}{l} 
Data Synchronization Pulse, Logic Input. Taking this input low initializes the internal logic in readiness for \\
a new data word.
\end{tabular} \\
5 & \(\overline{\text { LDAC }}\) & \begin{tabular}{l} 
Load DAC, Logic Input. Updates the DAC output. The DAC output is updated on the falling edge of this \\
signal, or alternatively if this line in permanently low, an automatic update mode is selected whereby the
\end{tabular} \\
6 & GND & \begin{tabular}{l} 
DAC is updated on the 16th falling SCLK pulse. \\
Ground pin \(=0 \mathrm{~V}\).
\end{tabular} \\
7 & \(\mathrm{~V}_{\text {OUT }}\) & \begin{tabular}{l} 
Analog Output Voltage. This is the buffered DAC output voltage \((-5 \mathrm{~V}\) to \(+5 \mathrm{~V})\). \\
8
\end{tabular} \\
\hline
\end{tabular}


\section*{ORDERING GUIDE}
\begin{tabular}{l|l|l|l}
\hline Model & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Relative \\
Accuracy
\end{tabular} & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD7233AN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\mathrm{N}-8\) \\
AD7233BN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\mathrm{N}-8\) \\
\hline
\end{tabular}
* \(\mathrm{N}=\) Plastic DIP. For outline information see Package Information section.

\section*{FEATURES}

Complete Dual 12-Bit DAC Comprising
Two 12-Bit CMOS DACs
On-Chip Voltage Reference
Output Amplifiers
Reference Buffer Amplifiers
Improved AD7237/AD7247:
12 V to 15 V Operation
Faster Interface - \(\mathbf{3 0}\) ns typ Data Setup Time
Parallel Loading Structure: AD7247A
(8+4) Loading Structure: AD7237A
Single or Dual Supply Operation
Low Power - 165 mW typ in Single Supply

\section*{GENERAL DESCRIPTION}

The AD7237A/AD7247A is an enhanced version of the industry standard AD7237/AD7247. Improvements include operation from 12 V to 15 V supplies, faster interface times and better reference variations with \(\mathrm{V}_{\mathrm{DD}}\). Additional features include faster settling times.
The AD7237A/AD7247A is a complete, dual, 12-bit, voltage output digital-to-analog converter with output amplifiers and Zener voltage reference on a monolithic CMOS chip. No external user trims are required to achieve full specified performance.
Both parts are microprocessor compatible, with high speed data latches and interface logic. The AD7247A accepts 12 -bit parallel data which is loaded into the respective DAC latch using the \(\overline{\mathrm{WR}}\) input and a separate Chip Select input for each DAC. The AD7237A has a double buffered interface structure and an 8-bit wide data bus with data loaded to the respective input latch in two write operations. An asynchronous LDAC signal on the AD7237A updates the DAC latches and analog outputs.
A REF OUT/REF IN function is provided which allows either the on-chip 5 V reference or an external reference to be used as a reference voltage for the part. For single supply operation, two output ranges of 0 to +5 V and 0 to +10 V are available, while these two ranges plus an additional +5 V range are available with dual supplies. The output amplifiers are capable of developing +10 V across a \(2 \mathrm{k} \Omega\) load to GND.
The AD7237A/AD7247A is fabricated in Linear Compatible CMOS (LC \({ }^{2}\) MOS), an advanced, mixed technology process that combines precision bipolar circuits with low power CMOS logic. Both parts are available in a 24 -pin, \(0.3^{\prime \prime}\) wide plastic and hermetic dual-in-line package (DIP) and are also packaged in a 24-lead small outline (SOIC) package.

DACPORT is a registered trademark of Analog Devices, Inc.

\section*{FUNCTIONAL BLOCK DIAGRAMS}


\section*{PRODUCT HIGHLIGHTS}
1. The AD7237A/AD7247A is a dual 12 -bit DACPORT® on a single chip. This single chip design and small package size offer considerable space saving and increased reliability over multichip designs.
2. The improved interface times of the parts allow easy, direct interfacing to most modern microprocessors, whether they have 8 -bit or 16 -bit data bus structures.
3. The AD7237A/AD7247A features a wide power supply range allowing operation from 12 V supplies.

AD7237A/AD7247A - SPECIFICATIONS \({ }^{\left(y_{0} 9\right.}=+12 v\) vo \(15 v v^{1} y_{s}=0 v_{0}-12 v\) to [AD7247A], REF \(\mathbb{N}=+5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}\). All specifications \(\mathrm{T}_{\min }\) to \(\mathrm{T}_{\max }\) unless otherwise noted.)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Parameter & \(\mathbf{A}^{\mathbf{2}}\) & \(\mathbf{B}^{2}\) & \(\mathrm{T}^{2}\) & Units & Test Conditions/Comments \\
\hline \begin{tabular}{l}
STATIC PERFORMANCE \\
Resolution \\
Relative Accuracy \({ }^{3}\) Differential Nonlinearity \({ }^{3}\) Unipolar Offset Error \({ }^{3}\) Bipolar Zero Error \({ }^{3}\) \\
Full-Scale Error \({ }^{3,5}\) Full-Scale Mismatch \({ }^{5}\)
\end{tabular} & \[
\begin{aligned}
& 12 \\
& \pm 1 \\
& \pm 0.9 \\
& \pm 3 \\
& \pm 6 \\
& \pm 5 \\
& \pm 1
\end{aligned}
\] & \[
\begin{aligned}
& 12 \\
& \pm 1 / 2 \\
& \pm 0.9 \\
& \pm 3 \\
& \pm 4 \\
& \\
& \pm 5 \\
& \pm 1
\end{aligned}
\] & \[
\begin{aligned}
& 12 \\
& \pm 1 / 2 \\
& \pm 0.9 \\
& \pm 4 \\
& \pm 6 \\
& \\
& \pm 6 \\
& \pm 1
\end{aligned}
\] & \begin{tabular}{l}
Bits \\
LSB max \\
LSB max \\
LSB max \\
LSB max \\
LSB max \\
LSB typ
\end{tabular} & \begin{tabular}{l}
Guaranteed Monotonic \\
\(\mathrm{V}_{\mathrm{ss}}=0 \mathrm{~V}\) or -12 V to \(-15 \mathrm{~V}^{4}\). DAC Latch Contents All 0 s \\
\(\mathrm{V}_{\mathrm{ss}}=-12 \mathrm{~V}\) to \(-15 \mathrm{~V}^{4}\). DAC Latch Contents \\
100000000000
\end{tabular} \\
\hline \begin{tabular}{l}
REFERENCE OUTPUT \\
REF OUT \\
Reference Temperature Coefficient Reference Load Change ( \(\triangle\) REF OUT vs. \(\Delta \mathrm{I}\) )
\end{tabular} & \[
\begin{aligned}
& 4.97 / 5.03 \\
& \pm 25 \\
& -1
\end{aligned}
\] & \[
\begin{aligned}
& 4.97 / 5.03 \\
& \pm 25 \\
& -1
\end{aligned}
\] & \[
\begin{aligned}
& 4.95 / 5.05 \\
& \pm 25 \\
& -1
\end{aligned}
\] & \(\mathrm{V} \min /\) max ppm \(/{ }^{\circ} \mathrm{C}\) typ mV max & Reference Load Current Change (0-100 \(\mu \mathrm{A}\) ) \\
\hline REFERENCE INPUT Reference Input Range Input Current \({ }^{6}\) & \[
\begin{aligned}
& 4.75 / 5.25 \\
& \pm 5
\end{aligned}
\] & \[
\begin{aligned}
& 4.75 / 5.25 \\
& \pm 5
\end{aligned}
\] & \[
\begin{aligned}
& 4.75 / 5.25 \\
& \pm 5
\end{aligned}
\] & \(\mathrm{V} \min / \max\) \(\mu \mathrm{A}\) max & \(5 \mathrm{~V} \pm 5 \%\) \\
\hline \begin{tabular}{l}
DIGITAL INPUTS \\
Input High Voltage, \(\mathrm{V}_{\text {INH }}\) Input Low Voltage, \(\mathrm{V}_{\text {INL }}\) Input Current \\
\(\mathrm{I}_{\mathrm{IN}}\) (Data Inputs) \\
Input Capacitance \({ }^{6}\)
\end{tabular} & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 10 \\
& 8
\end{aligned}
\] & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 10 \\
& 8
\end{aligned}
\] & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 10 \\
& 8
\end{aligned}
\] & \begin{tabular}{l}
\(V_{\text {min }}\) \\
\(V_{\text {max }}\) \\
\(\mu \mathrm{A}\) max \\
pF max
\end{tabular} & \(\mathrm{V}_{\text {IN }}=0 \mathrm{~V}\) to \(\mathrm{V}_{\mathrm{DD}}\) \\
\hline ANALOG OUTPUTS Output Range Resistors Output Voltage Ranges \({ }^{7}\) Output Voltage Ranges \({ }^{7}\) DC Output Impedance & \[
\begin{aligned}
& 15 / 30 \\
& +5,+10 \\
& +5,+10, \pm 5 \\
& 0.5
\end{aligned}
\] & \[
\begin{aligned}
& 15 / 30 \\
& +5,+10 \\
& +5,+10, \pm 5 \\
& 0.5
\end{aligned}
\] & \[
\begin{aligned}
& 15 / 30 \\
& +5,+10, \pm 5 \\
& 0.5
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{k} \Omega \min / \max \\
& \mathrm{V} \\
& \Omega \text { typ }
\end{aligned}
\] & \begin{tabular}{l}
Single Supply; \(\left(\mathrm{V}_{\mathrm{ss}}=0 \mathrm{~V}\right)\) \\
Dual Supply; \(\left(\mathrm{V}_{\mathrm{ss}}=-12 \mathrm{~V}\right.\) to \(\left.-15 \mathrm{~V}^{4}\right)\)
\end{tabular} \\
\hline \begin{tabular}{l}
AC CHARACTERISTICS \({ }^{6}\) \\
Voltage Output Settling Time \\
Positive Full-Scale Change \\
Negative Full-Scale Change \\
Digital-to-Analog Glitch Impulse \({ }^{3}\) \\
Digital Feedthrough \({ }^{3}\) \\
Digital Crosstalk \({ }^{3}\)
\end{tabular} & 8
8

30
10
30 & \[
\begin{aligned}
& 8 \\
& 8 \\
& 30 \\
& 10 \\
& 30
\end{aligned}
\] & \[
\begin{aligned}
& 10 \\
& 10 \\
& 30 \\
& 10 \\
& 30
\end{aligned}
\] & \begin{tabular}{l}
\(\mu \mathrm{s}\) max \(\mu \mathrm{s} \max\) \\
nV secs typ \\
nV secs typ \\
nV secs typ
\end{tabular} & \begin{tabular}{l}
Settling Time to Within \(\pm 1 / 2\) LSB of Final Value \\
DAC Latch all 0 s to all 1 s . Typically \(5 \mu \mathrm{~s}\) \\
DAC Latch all 1 s to all 0 s . Typically \(5 \mu \mathrm{~s}\)
\[
\mathrm{V}_{\mathrm{ss}}=-12 \mathrm{~V} \text { to }-15 \cdot \mathrm{~V}^{4} .
\] \\
DAC Latch Contents Toggled Between all 0's and all l's.
\end{tabular} \\
\hline \begin{tabular}{l}
POWER REQUIREMENTS \\
\(\mathrm{V}_{\mathrm{DD}}\) \\
\(\mathrm{V}_{\mathrm{ss}}\) \\
\(\mathrm{I}_{\mathrm{DD}}\) \\
\(\mathrm{I}_{\text {SS }}\) (Dual Supplies)
\end{tabular} & \[
\begin{aligned}
& +10.8 /+16.5 \\
& -10.8 /-16.5 \\
& 15 \\
& 5
\end{aligned}
\] & \[
\begin{aligned}
& +11.4 /+15.75 \\
& -11.4 /-15.75 \\
& 15 \\
& 5
\end{aligned}
\] & \[
\begin{aligned}
& +11.4 /+15.75 \\
& -11.4 /-15.75 \\
& 15 \\
& 5
\end{aligned}
\] & \begin{tabular}{l}
V min/max \\
\(\mathrm{V} \min / \max\) \\
mA max \\
\(m A\) max
\end{tabular} & For Specified Performance Unless Otherwise Stated For Specified Performance Unless Otherwise Stated Output Unloaded. Typically 10 mA Output Unloaded. Typically 3 mA \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Power Supply tolerance is \(\pm 10 \%\) for A version and \(\pm 5 \%\) for B and T versions.
\({ }^{2}\) Temperature ranges are as follows: A, B Versions, \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\); T Version, \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\).
\({ }^{3}\) See Terminology.
\({ }^{4}\) With appropriate power supply tolerances.
\({ }^{5}\) Measured with respect to REF IN and includes unipolar/bipolar offset error.
\({ }^{6}\) Sample tested \(@+25^{\circ} \mathrm{C}\) to ensure compliance.
\({ }^{7} 0\) to +10 V range is only available with \(\mathrm{V}_{\mathrm{DD}} \geq 14.25 \mathrm{~V}\).
Specifications subject to change without notice.

\begin{tabular}{l|l|l|l}
\hline Parameter & \begin{tabular}{l} 
Limit at \(\mathbf{T}_{\text {min }}, \mathbf{T}_{\text {max }}\) \\
(A, B Versions)
\end{tabular} & \begin{tabular}{l} 
Limit at \(\mathbf{T}_{\text {min }}, \mathbf{T}_{\text {max }}\) \\
(T Version)
\end{tabular} & Units
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Sample tested at \(+25^{\circ} \mathrm{C}\) to ensure compliance. All input signals are specified with \(\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%\) to \(90 \%\) of 5 V\()\) and timed from a voltage level of 1.6 V .
\({ }^{2}\) See Figures 5 and 7.
\({ }^{3}\) Power Supply tolerance is \(\pm 10 \%\) for \(A\) version and \(\pm 5 \%\) for \(B\) and \(T\) versions.
\({ }^{4}\) If \(0 \mathrm{~ns}<\mathrm{t}_{2}<10 \mathrm{~ns}\), add \(\mathrm{t}_{2}\) to \(\mathrm{t}_{5}\). If \(\mathrm{t}_{2} \geq 10 \mathrm{~ns}\), add 10 ns to \(\mathrm{t}_{5}\).
\({ }^{5}\) AD7237A only.

\section*{ABSOLUTE MAXIMUM RATINGS*}
( \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) unless otherwise noted)
\(\mathrm{V}_{\mathrm{DD}}\) to GND (AD7247A) . . . . . . . . . . . . -0.3 V to +17 V
\(\mathrm{V}_{\mathrm{DD}}\) to AGND, DGND (AD7237A) . . . . . -0.3 V to +17 V
\(\mathrm{V}_{\mathrm{DD}}\) to \(\mathrm{V}_{\text {SS }} \ldots . . . . . . . . . . . . . . . . .-0.3 \mathrm{~V}\) to +34 V
AGND to DGND (AD7237A) . . . . . . \(-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
\(\mathrm{V}_{\text {OUTA }}{ }^{1}, \mathrm{~V}_{\text {OUtB }}{ }^{1}\) to AGND (GND) . . . . . . . . . . . . . . . . . . . . \(V_{S S}-0.3 V\) to \(V_{D D}+0.3 \mathrm{~V}\)
REF OUT to AGND (GND) . . . . . . . . . . . . . 0 V to \(\mathrm{V}_{\mathrm{DD}}\)
REF IN to AGND (GND) . . . . . . -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
Digital Inputs to DGND (GND) . . . -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
Operating Temperature Range
Industrial (A, B Versions) . . . . . . . . . . . . \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
Extended (T Version) . . . . . . . . . . . . . . \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
Storage Temperature Range . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Lead Temperature (Soldering, 10 secs) . . . . . . . . . . . \(+300^{\circ} \mathrm{C}\)
Power Dissipation (Any Package) to \(+75^{\circ} \mathrm{C} \ldots . . . .1000 \mathrm{~mW}\)
Derates above \(+75^{\circ} \mathrm{C}\) by . . . . . . . . . . . . . . . . \(10 \mathrm{~mW} /{ }^{\circ} \mathrm{C}\)
NOTE
\({ }^{1}\) Short-circuit current is typically 80 mA . The outputs may be shorted to voltages in this range provided the power dissipation of the package is not exceeded.
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

\section*{ORDERING GUIDE}
\begin{tabular}{l|l|l|l}
\hline & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Relative \\
Accuracy \\
(LSB)
\end{tabular} & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD7237AAN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \max\) & \(\mathrm{~N}-24\) \\
AD7237ABN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \max\) & \(\mathrm{~N}-24\) \\
AD7237AAR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \max\) & \(\mathrm{R}-24\) \\
AD7237ABR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \max\) & \(\mathrm{R}-24\) \\
AD7237ATQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \max\) & \(\mathrm{Q}-24\) \\
AD7247AAN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \max\) & \(\mathrm{~N}-24\) \\
AD7247ABN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \max\) & \(\mathrm{~N}-24\) \\
AD7247AAR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \max\) & \(\mathrm{R}-24\) \\
AD7247ABR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \max\) & \(\mathrm{R}-24\) \\
AD7247ATQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \max\) & \(\mathrm{Q}-24\) \\
\hline
\end{tabular}

NOTES
\({ }^{1}\) To order MIL-STD-883, Class B processed parts, add /883B to part number. Contact local sales office for military data sheet and availability.
\({ }^{2} \mathrm{~N}=\) Plastic DIP; Q = Cerdip; R = Small Outline (SOIC). For outline information see Package Information section.

\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD7237A/AD7247A features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

\section*{AD7237A PIN FUNCTION DESCRIPTION (DIP PIN NUMBERS)}
\begin{tabular}{|c|c|c|}
\hline Pin & Mnemonic & Description \\
\hline 1 & REF INA & Voltage Reference Input for DAC A. The reference voltage for DAC A is applied to this pin. It is internally buffered before being applied to the DAC. The nominal reference voltage for correct operation of the AD7237A is 5 V . \\
\hline 2 & REF OUT & Voltage Reference Output. The internal 5 V analog reference is provided at this pin. To operate the part with internal reference, REF OUT should be connected to REF INA, REF INB. \\
\hline 3 & REF INB & Voltage Reference Input for DAC B. The reference voltage for DAC B is applied to this pin. It is internally buffered before being applied to the DAC. The nominal reference voltage for correct operation of the AD7237A is 5 V . \\
\hline 4 & \(\mathrm{R}_{\text {OFSB }}\) & Output Offset Resistor for DAC B. This input configures the output ranges for DAC B. It is connected to \(\mathrm{V}_{\text {Outb }}\) for the +5 V range, to AGND for the +10 V range and to REF INB for the \(\pm 5 \mathrm{~V}\) range. \\
\hline 5 & \(\mathrm{V}_{\text {OUtB }}\) & Analog Output Voltage from DAC B. This is the buffer amplifier output voltage. Three different output voltage ranges can be chosen: 0 to \(+5 \mathrm{~V}, 0\) to +10 V and \(\pm 5 \mathrm{~V}\). The amplifier is capable of developing +10 V across a \(2 \mathrm{k} \Omega\) resistor to GND. \\
\hline 6 & AGND & Analog Ground. Ground reference for DACs, reference and output buffer amplifiers. \\
\hline 7 & DB7 & Data Bit 7. \\
\hline 8-10 & DB6-DB4 & Data Bit 6 to Data Bit 4. \\
\hline 11 & DB3 & Data Bit 3/Data Bit 11 (MSB). \\
\hline 12 & DGND & Digital Ground. Ground reference for digital circuitry. \\
\hline 13 & DB2 & Data Bit 2/Data Bit 10. \\
\hline 14 & DB1 & Data Bit 1/Data Bit 9. \\
\hline 15 & DB0 & Data Bit 0 (LSB)/Data Bit 8. \\
\hline 16 & A0 & Address Input. Least significant address input for input latches. A0 and A1 select which of the four input latches data is written to (see Table II). \\
\hline 17 & A1 & Address Input. Most significant address input for input latches. \\
\hline 18 & \(\overline{\mathrm{CS}}\) & Chip Select. Active low logic input. The device is selected when this input is active. \\
\hline 19 & \(\overline{\mathrm{WR}}\) & Write Input. \(\overline{\mathrm{WR}}\) is an active low logic input which is used in conjunction with \(\overline{\mathrm{CS}}, \mathrm{A} 0\) and A 1 to write data to the input latches. \\
\hline 20 & \(\overline{\text { LDAC }}\) & Load DAC. Logic input. A new word is loaded into the DAC latches from the respective input latches on the falling edge of this signal. \\
\hline 21 & \(\mathrm{V}_{\mathrm{DD}}\) & Positive Supply ( +12 V to +15 V ). \\
\hline 22 & \(\mathrm{V}_{\text {OUTA }}\) & Analog Output Voltage from DAC A. This is the buffer amplifier output voltage. Three different output voltage ranges can be chosen: 0 to \(+5 \mathrm{~V}, 0\) to +10 V and \(\pm 5 \mathrm{~V}\). The amplifier is capable of developing +10 V across a \(2 \mathrm{k} \Omega\) resistor to GND. \\
\hline 23 & \(\mathrm{V}_{\text {ss }}\) & Negative Supply ( 0 V or -12 V to -15 V ). \\
\hline 24 & \(\mathrm{R}_{\text {OFSA }}\) & Output Offset Resistor for DAC A. This input configures the output ranges for DAC A. It is connected to \(\mathrm{V}_{\text {OUTA }}\) for the +5 V range, to AGND for the +10 V range and to REF INA for the \(\pm 5 \mathrm{~V}\) range. \\
\hline
\end{tabular}

\section*{AD7247A PIN FUNCTION DESCRIPTION (DIP PIN NUMBERS)}
\begin{tabular}{|c|c|c|}
\hline Pin & Mnemonic & Description \\
\hline 1 & REF OUT & Voltage Reference Output. The internal 5 V analog reference is provided at this pin. To operate the part with internal reference, REF OUT should be connected to REF IN. \\
\hline 2 & \(\mathrm{R}_{\text {OFSB }}\) & Output Offset Resistor for DAC B. This input configures the output ranges for DAC B. It is connected to \(\mathrm{V}_{\text {Outb }}\) for the +5 V range, to GND for the +10 V range and to REF IN for the \(\pm 5 \mathrm{~V}\) range. \\
\hline 3 & \(\mathrm{V}_{\text {OUTB }}\) & Analog Output Voltage from DAC B. This is the buffer amplifier output voltage. Three different output voltage ranges can be chosen: 0 to \(+5 \mathrm{~V}, 0\) to +10 V and \(\pm 5 \mathrm{~V}\). The amplifier is capable of developing +10 V across a \(2 \mathrm{k} \Omega\) resistor to GND. \\
\hline 4 & DB11 & Data Bit 11 (MSB). \\
\hline 5 & DB10 & Data Bit 10. \\
\hline 6 & GND & Ground. Ground reference for all on-chip circuitry. \\
\hline 7-15 & DB9-DB1 & Data Bit 9 to Data Bit 1. \\
\hline 16 & DB0 & Data Bit 0 (LSB). \\
\hline 17 & \(\overline{\mathrm{CSB}}\) & Chip Select Input for DAC B. Active low logic input. DAC B is selected when this input is active. \\
\hline 18 & \(\overline{\mathrm{CSA}}\) & Chip Select Input for DAC A. Active low logic input. DAC A is selected when this input is active. \\
\hline 19 & \(\overline{\mathrm{WR}}\) & Write Input. \(\overline{\mathrm{WR}}\) is an active low logic input which is used in conjunction with \(\overline{\mathrm{CSA}}\) and \(\overline{\mathrm{CSB}}\) to write data to the DAC latches. \\
\hline 20 & \(\mathrm{V}_{\text {DD }}\) & Positive Supply ( +12 V to +15 V ). \\
\hline 21 & \(\mathrm{V}_{\text {OUTA }}\) & Analog Output Voltage from DAC A. This is the buffer amplifier output voltage. Three different output voltage ranges can be chosen: 0 to \(+5 \mathrm{~V}, 0\) to +10 V and \(\pm 5 \mathrm{~V}\). The amplifier is capable of developing +10 V across a \(2 \mathrm{k} \Omega\) resistor to GND. \\
\hline 22 & \(\mathrm{V}_{\text {SS }}\) & Negative Supply ( 0 V or -12 V to -15 V ). \\
\hline 23 & \(\mathrm{R}_{\text {OFSA }}\) & Output Offset Resistor for DAC A. This input configures the output ranges for DAC A. It is connected to \(\mathrm{V}_{\text {OUtA }}\) for the +5 V range, to GND for the +10 V range and to REF IN for the \(\pm 5 \mathrm{~V}\) range. \\
\hline 24 & REF IN & Voltage Reference Input. The common reference voltage for both DACs is applied to this pin. It is internally buffered before being applied to both DACs. The nominal reference voltage for correct operation of the AD7247A is 5 V . \\
\hline
\end{tabular}

\section*{AD7237A PIN CONFIGURATIONS}

DIP and SOIC


\section*{AD7247A PIN CONFIGURATIONS}

DIP and SOIC


\section*{AD7237A/AD7247A}


Figure 1. AD7247A Write Cycle Timing Diagram


Figure 2. AD7237A Write Cycle Timing Diagram

\section*{FEATURES}

Two 12-Bit/14-Bit DACs with Output Amplifiers
AD7242: 12-Bit Resolution
AD7244: 14-Bit Resolution
On-Chip Voltage Reference
Fast Settling Time
AD7242: \(3 \mu \mathrm{~s}\) to \(\pm 1 / 2\) LSB
AD7244: \(4 \mu \mathrm{~s}\) to \(\pm 1 / 2\) LSB
High Speed Serial Interface
Operates from \(\pm 5\) V Supplies
Specified Over \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) in Plastic Packages Low Power - 130 mW typ

\section*{GENERAL DESCRIPTION}

The AD7242/AD7244 is a fast, complete, dual 12-bit/14-bit voltage output D/A converter. It consists of a 12 -bit/14-bit DAC, 3 V buried Zener reference, DAC output amplifiers and high speed serial interface logic.
Interfacing to both DACs is serial, minimizing pin count and allowing a small package size. Standard control signals allow interfacing to most DSP processors and microcontrollers. Asynchronous control of DAC updating for both DACs is made possible with a separate \(\overline{\text { LDAC input for each DAC. }}\)
The AD7242/AD7244 operates from \(\pm 5 \mathrm{~V}\) power supplies, providing an analog output range of \(\pm 3 \mathrm{~V}\). A REF OUT/REF IN function allows the DACs to be driven from the on-chip 3 V reference or from an external reference source.

The AD7242/AD7244 is fabricated in Linear Compatible CMOS ( \(\mathrm{LC}^{2} \mathrm{MOS}\) ), an advanced mixed technology process that combines precision bipolar circuits with low power CMOS logic. Both parts are available in a 24 -pin, 0.3 inch wide, plastic or hermetic dual-in-line package (DIP) and in a 28 -pin, plastic small outline (SOIC) package. The AD7242 and AD7244 are available in the same pinout to allow easy upgrade from 12-bit to 14-bit performance.

\section*{FUNCTIONAL BLOCK DIAGRAM}


\section*{PRODUCT HIGHLIGHTS}
1. Complete, Dual 12-Bit/14-Bit DACs

The AD7242/AD7244 provides the complete function for generating voltages to 12 -bit/14-bit resolution. The part features an on-chip reference, output buffer amplifiers and two 12-bit/14-bit D/A converters.
2. High Speed Serial Interface The AD7242/AD7244 provides a high speed, easy-to-use, serial interface allowing direct interfacing to DSP processors and microcontrollers. A separate serial port is provided for each DAC.
3. Small Package Size

The AD7242/AD7244 is available in a 24 -pin DIP and a 28 pin SOIC package offering considerable space saving over comparable solutions.

This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

AD7242/AD72AA
\(=2 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}\). All Specifications \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) unless otherwise noted.)


NOTES
\({ }^{1}\) Temperature ranges are as follows: \(\mathrm{J}, \mathrm{K}\) Versions: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\); A, B Versions: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\).
\({ }^{2}\) Measured with respect to REF IN and includes bipolar offset error.
\({ }^{3}\) For capacitive loads greater than 50 pF a series resistor is required (see Internal Reference section).
\({ }^{4}\) Sample tested @ \(+25^{\circ} \mathrm{C}\) to ensure compliance.
Specifications subject to change without notice.
AD7242 ORDERING GUIDE
\begin{tabular}{l|l|l|l}
\hline Model & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Integral \\
Nonlinearity
\end{tabular} & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD7242JN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1\) LSB max & \(\mathrm{N}-24\) \\
AD7242KN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB} \max\) & \(\mathrm{N}-24\) \\
AD7242JR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB} \max\) & \(\mathrm{R}-28\) \\
AD7242KR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB} \max\) & \(\mathrm{R}-28\) \\
AD7242AQ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB} \max\) & \(\mathrm{Q}-24\) \\
AD7242BQ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB} \max\) & \(\mathrm{Q}-24\) \\
\hline
\end{tabular}

\footnotetext{
* \(\mathrm{N}=\) Plastic DIP; \(\mathrm{Q}=\) Cerdip; \(\mathrm{R}=\) Small Outline IC (SOIC). For outline information see Package Information section.
}
\begin{tabular}{|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Parameter} & \multicolumn{2}{|l|}{AD7244} & \multirow[b]{2}{*}{Units} & \multirow[b]{2}{*}{Test Conditions/Comments} \\
\hline & J/A Versions \({ }^{1}\) & S Version \({ }^{1}\) & & \\
\hline \multicolumn{5}{|l|}{DC ACCURACY} \\
\hline Resolution & 14 & 14 & Bits & \\
\hline Integral Nonlinearity & \(\pm 2\) & \(\pm 2\) & LSB max & \\
\hline Differential Nonlinearity & \(\pm 1\) & \(\pm 1\) & LSB max & Guaranteed Monotonic \\
\hline Bipolar Zero Error & \(\pm 10\) & \(\pm 15\) & LSB max & \\
\hline Positive Full-Scale Error \({ }^{2}\) & \(\pm 10\) & \(\pm 15\) & LSB max & \\
\hline Negative Full-Scale Error \({ }^{2}\) & \(\pm 10\) & \(\pm 15\) & LSB max & \\
\hline \multicolumn{5}{|l|}{REFERENCE OUTPUT \({ }^{3}\)} \\
\hline REF OUT @ + \(25^{\circ} \mathrm{C}\) & 2.99/3.01 & 2.99/3.01 & \(V \min / \mathrm{V}\) max & \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & 2.98/3.02 & 2.93/3.05 & \(\mathrm{V} \min / \mathrm{V} \max\) & \\
\hline REF OUT Tempco & 35 & 35 & ppm \(/{ }^{\circ} \mathrm{C}\) typ & \\
\hline Reference Load Change ( \(\Delta\) REF OUT vs. \(\Delta \mathrm{I}\) ) & -1 & \[
-1
\] & \[
\operatorname{mV} \max
\] & Reference Load Current Change (0-500 \(\mu \mathrm{A}\) ) \\
\hline \multicolumn{5}{|l|}{REFERENCE INPUTS} \\
\hline REF INA, REF INB Input Range & 2.85/3.15 & 2.85/3.15 & \(\mathrm{V} \min / \mathrm{V}\) max & \(3 \mathrm{~V} \pm 5 \%\) \\
\hline Input Current & 1 & 1 & \(\mu \mathrm{A}\) max & \\
\hline \multicolumn{5}{|l|}{LOGIC INPUTS} \\
\hline ( \(\overline{\text { LDACA }}, \overline{\text { LDACB }}, \overline{\text { TFSA }}, \overline{\text { TFSB }}\), & & & & \\
\hline TCLKA, TCLKB, DTA, DTB) & & & & \\
\hline Input High Voltage, \(\mathrm{V}_{\text {INH }}\) & 2.4 & 2.4 & V min & \(\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \%\) \\
\hline Input Low Voltage, \(\mathrm{V}_{\text {INL }}\) & 0.8 & 0.8 & \(V\) max & \(\mathrm{V}_{\text {DD }}=5 \mathrm{~V} \pm 5 \%\) \\
\hline Input Current, \(\mathrm{I}_{\text {IN }}\) & \(\pm 10\) & \(\pm 10\) & \(\mu \mathrm{A}\) max & \(\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}\) to \(\mathrm{V}_{\mathrm{DD}}\) \\
\hline Input Capacitance, \(\mathrm{C}_{\mathrm{IN}}{ }^{4}\) & 10 & 10 & pF max & \\
\hline \multicolumn{5}{|l|}{ANALOG OUTPUTS} \\
\hline ( \(\mathrm{V}_{\text {OUTA }}, \mathrm{V}_{\text {OUTB }}\) ) & & & & \\
\hline Output Voltage Range & \(\pm 3\) & \(\pm 3\) & \(V\) nom & \\
\hline DC Output Impedance & 0.1 & 0.1 & \(\Omega\) typ & \\
\hline Short Circuit Current & 20 & 20 & mA typ & \\
\hline \multicolumn{5}{|l|}{AC CHARACTERISTICS \({ }^{4}\)} \\
\hline Voltage Output Settling Time & & & & Settling Time to Within \(\pm 1 / 2\) LSB of Final Value \\
\hline Positive Full-Scale Change & 4 & 4 & \(\mu \mathrm{s}\) max & Typically \(2.5 \mu \mathrm{~s}\) \\
\hline Negative Full-Scale Change & 4 & 4 & \(\mu s\) max & Typically \(2.5 \mu \mathrm{~s}\) \\
\hline Digital-to-Analog Glitch Impulse & 10 & 10 & nV secs typ & DAC Code Change All 1 s to All 0s \\
\hline Digital Feedthrough & 2 & 2 & nV secs typ & \\
\hline Channel-to-Channel Isolation & 110 & 110 & dB typ & \(\mathrm{V}_{\text {OUT }}=10 \mathrm{kHz}\) Sine Wave \\
\hline \multicolumn{5}{|l|}{POWER REQUIREMENTS} \\
\hline \(\mathrm{V}_{\text {DD }}\) & "+5 & +5 & \(V\) nom & \(\pm 5 \%\) for Specified Performance \\
\hline \(\mathrm{V}_{\text {Ss }}\) & -5 & -5 & \(V\) nom & \(\pm 5 \%\) for Specified Performance \\
\hline \(\mathrm{I}_{\text {DD }}\) & 27 & 28 & mA max & Cumulative Current from the Two \(\mathrm{V}_{\mathrm{DD}}\) Pins \\
\hline \(\mathrm{I}_{\text {SS }}\) & 15 & 15 & mA max & Cumulative Current from the Two \(\mathrm{V}_{\text {ss }}\) Pins \\
\hline Total Power Dissipation & 195 & 205 & mW max & Typically 130 mW \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Temperature ranges are as follows: J Version: \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\); A Version: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\); S Version: \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\).
\({ }^{2}\) Measured with respect to REF IN and includes bipolar offset error.
\({ }^{3}\) For capacitive loads greater than 50 pF a series resistor is required (see Internal Reference section).
\({ }^{4}\) Sample tested @ \(+25^{\circ} \mathrm{C}\) to ensure compliance.
Specifications subject to change without notice.

\section*{AD7244 ORDERING GUIDE}
\begin{tabular}{l|l|l|l}
\hline Model \(^{\mathbf{1}}\) & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Integral \\
Nonlinearity
\end{tabular} & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD7244JN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 2\) LSB max & \(\mathrm{N}-24\) \\
AD7244JR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 2\) LSB max & \(\mathrm{R}-28\) \\
AD7244AQ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 2\) LSB max & \(\mathrm{Q}-24\) \\
AD7244SQ \(^{3}\) & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 2\) LSB max & \(\mathrm{Q}-24\) \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) To order MIL-STD-883, Class B, processed parts, add /883B to part number. Contact local sales office for military data sheet and availability.
\({ }^{2} \mathrm{~N}=\) Plastic DIP; Q = Cerdip; R = Small Outline IC (SOIC). For outline information see Package Information section.
\({ }^{3}\) This grade will be available to \(/ 883 \mathrm{~B}\) processing only.

TIMING CHARACTERISTICS \({ }^{1,2}{ }_{\left(v_{D O}\right.}=+5 \mathrm{v} \pm 5 \%, \mathrm{~V}_{\mathrm{SS}}=-5 \mathrm{v} \pm 5 \%\), AGND \(=\) DGND \(\left.=0 \mathrm{~V}\right)\)
\begin{tabular}{|c|c|c|c|c|}
\hline Parameter & Limit at \(T_{\text {min }}, T_{\text {max }}\) (J, K, A, B Versions) & Limit at \(\mathbf{T}_{\text {min }}, \mathbf{T}_{\text {max }}\) (S Version) & Units & Conditions/Comments \\
\hline \(\mathrm{t}_{1}\) & 50 & 50 & ns min & \(\overline{\mathrm{TFS}}\) to TCLK Falling Edge \\
\hline \(\mathrm{t}_{2}\) & 75 & 100 & ns min & TCLK Falling Edge to TFS \\
\hline \(\mathrm{t}_{3}{ }^{3}\) & 150 & 200 & ns min & TCLK Cycle Time \\
\hline \(\mathrm{t}_{4}\) & 30 & 40 & ns min & Data Valid to TCLK Setup Time \\
\hline \(\mathrm{t}_{5}\) & 75 & 100 & ns min & Data Valid to TCLK Hold Time \\
\hline \(\mathrm{t}_{6}\) & 40 & 40 & ns min & LDAC Pulse Width \\
\hline
\end{tabular}

NOTES
\({ }^{1}\) Timing specifications are sample tested at \(+25^{\circ} \mathrm{C}\) to ensure compliance. All input signals are specified with \(\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%\) to \(90 \%\) of 5 V\()\) and timed from a voltage level of 1.6 V .
\({ }^{2}\) See Figure 6.
\({ }^{3}\) TCLK Mark/Space ratio is \(40 / 60\) to \(60 / 40\).

\section*{ABSOLUTE MAXIMUM RATINGS*}
( \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) unless otherwise noted)
\(\mathrm{V}_{\mathrm{DD}}\) to AGND . . . . . . . . . . . . . . . . . . . . -0.3 V to +7 V
\(\mathrm{V}_{\mathrm{ss}}\) to AGND . . . . . . . . . . . . . . . . . . . . . +0.3 V to -7 V
AGND to DGND . . . . . . . . . . . . . -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
\(\mathrm{V}_{\text {Out }}\) to AGND . . . . . . . . . . . . . . . . . . . . . . \(\mathrm{V}_{\text {ss }}\) to \(\mathrm{V}_{\mathrm{DD}}\)
REF OUT to AGND . . . . . . . . . . . -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
REF INA, REF INB to AGND \(\ldots,-0.3 \mathrm{~V}\) to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
Digital Inputs to DGND . . . . . . . . . 0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
Operating Temperature Range
J, K Versions
\begin{tabular}{|c|c|}
\hline AD7244 & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) \\
\hline AD7242 & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) \\
\hline A, B Versions & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) \\
\hline S Version & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) \\
\hline torage Temperature Range & \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\) \\
\hline Lead Temperature (Soldering, 10 secs) & \(+300^{\circ} \mathrm{C}\) \\
\hline er Dissipation (Any Package) to \(+75^{\circ} \mathrm{C}\) & 550 m \\
\hline ates above \(+75^{\circ} \mathrm{C}\) by & \(6 \mathrm{~mW} /{ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

CAUTION
ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are inserted.


PIN CONFIGURATIONS
 LC²MOS

\section*{FEATURES}

12-Bit CMOS DAC with
On-Chip Voltage Reference
Output Amplifier
3 Selectable Output Ranges
-5 V to \(+5 \mathrm{~V}, 0\) to \(+5 \mathrm{~V}, 0\) to +10 V
Serial Interface
300 kHz DAC Update Rate
Small Size: 16-Pin DIP or SOIC
Nonlinearity: \(\pm \mathbf{1 / 2}\) LSB \(T_{\text {min }}\) to \(T_{\text {max }}\)
Low Power Dissipation: 100 mW typical
APPLICATIONS
Process Control
Industrial Automation
Digital Signal Processing Systems
Input/Output Ports

\section*{GENERAL DESCRIPTION}

The AD7243 is a complete 12 -bit, voltage output, digital-toanalog converter with output amplifier and Zener voltage reference on a monolithic CMOS chip. No external trims are required to achieve full specified performance.
The output amplifier is capable of developing +10 V across a \(2 \mathrm{k} \Omega\) load. The output voltage ranges with single supply operation are 0 to +5 V or 0 to +10 V , while an additional bipolar \(\pm 5 \mathrm{~V}\) output range is available with dual supplies. The ranges are selected using the internal gain resistor.
The data format is natural binary in both unipolar ranges, while either offset binary or 2 s complement format may be selected in the bipolar range. A \(\overline{\mathrm{CLR}}\) function is provided which sets the output to 0 V in both unipolar ranges and in the 2 s complement bipolar range, while with offset binary data format, the output is set to -REFIN. This function is useful as a power-on reset as it allows the output to be set to a known voltage level.

The AD7243 features a fast versatile serial interface which allows easy connection to both microcomputers and 16 -bit digital signal processors with serial ports. The serial data may be applied at rates up to 5 MHz allowing a DAC update rate of 300 kHz . A serial data output capability is also provided which allows daisy chaining in multi-DAC systems. This feature allows any number of DACs to be used in a system with a simple 4 -wire interface. All DACs may be updated simultaneously using LDAC.

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\section*{FUNCTIONAL BLOCK DIAGRAM}

The AD7243 is fabricated on Linear Compatible CMOS (LC \({ }^{2}\) MOS), an advanced, mixed technology process. It is packaged in 16-pin DIP and 16-pin SOIC packages.

\section*{PRODUCT HIGHLIGHTS}
1. Complete 12 -Bit DACPORT \({ }^{\circledR}\)

The AD7243 is a complete, voltage output, 12-bit DAC on a single chip. The single chip design is inherently more reliable than multichip designs.
2. Single or Dual Supply Operation.
3. Minimum 3-wire interface to most DSP processors.
4. DAC Update Rate- 300 kHz .
5. Serial Data Output allows easy daisy-chaining in multiple DAC systems.


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\(\left(V_{D 0}=+12 \mathrm{~V}\right.\) to \(+15 \mathrm{~V},{ }^{1} \mathrm{~V}_{\mathrm{Ss}}=0 \mathrm{~V}\) or -12 V to \(-15 \mathrm{~V},{ }^{1}\)

\begin{tabular}{|c|c|c|c|c|c|}
\hline Parameter & \(\mathbf{A}^{2}\) & \(\mathbf{B}^{2}\) & \(\mathbf{S}^{2}\) & Units & Test Conditions/Comments \\
\hline \begin{tabular}{l}
STATIC PERFORMANCE \\
Resolution \\
Relative Accuracy \({ }^{3}\) \\
Differential Nonlinearity \({ }^{3}\) \\
Unipolar Offset Error \({ }^{3}\) \\
Bipolar Zero Error \({ }^{3}\) \\
Full-Scale Error \({ }^{3,4}\) \\
Full-Scale Temperature Coefficient
\end{tabular} & \[
\begin{aligned}
& 12 \\
& \pm 1 \\
& \pm 0.9 \\
& \pm 4 \\
& \pm 5 \\
& \pm 6 \\
& \pm 5
\end{aligned}
\] & \[
\begin{aligned}
& 12 \\
& \pm 1 / 2 \\
& \pm 0.9 \\
& \pm 4 \\
& \\
& \pm 5 \\
& \pm 6 \\
& \pm 5
\end{aligned}
\] & \[
\begin{aligned}
& 12 \\
& \pm 1 \\
& \pm 0.9 \\
& \pm 5 \\
& \\
& \pm 6 \\
& \pm 7 \\
& \pm 5
\end{aligned}
\] & \begin{tabular}{l}
Bits \\
LSB max \\
LSB max \\
LSB max \\
LSB max \\
LSB max \\
ppm of FSR/ \\
\({ }^{\circ} \mathrm{C}\) typ
\end{tabular} & \begin{tabular}{l}
Guaranteed Monotonic \\
\(\mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}\) or -12 V to \(-15 \mathrm{~V} ;{ }^{1}\) DAC Latch \\
Contents All Os \\
\(\mathrm{V}_{\mathrm{SS}}=-12 \mathrm{~V}\) to \(-15 \mathrm{~V}^{1}\); DAC Latch Contents All 0
\end{tabular} \\
\hline \begin{tabular}{l}
REFERENCE OUTPUT REFOUT \\
Reference Temperature Coefficient Reference Load Change ( \(\triangle\) REFOUT vs. \(\mathrm{I}_{\mathrm{L}}\) )
\end{tabular} & \[
\begin{aligned}
& 4.95 / 5.05 \\
& \pm 25 \\
& -1
\end{aligned}
\] & \[
\begin{aligned}
& 4.95 / 5.05 \\
& \pm 25 \\
& -1
\end{aligned}
\] & \[
\left\lvert\, \begin{aligned}
& 4.95 / 5.05 \\
& \pm 30 \\
& \\
& -1
\end{aligned}\right.
\] & \begin{tabular}{l}
\(\mathrm{V} \min / \mathrm{V} \max\) ppm \(/{ }^{\circ} \mathrm{C}\) typ \\
mV max
\end{tabular} & Reference Load Current ( \(\mathrm{I}_{\mathrm{L}}\) ) Change (0-100 \(\mu \mathrm{A}\) ) \\
\hline \begin{tabular}{l}
REFERENCE INPUT \\
Reference Input Range, REFIN Input Current
\end{tabular} & \[
\begin{aligned}
& \text { 4.95/5.05 } \\
& 5
\end{aligned}
\] & \[
\begin{aligned}
& 4.95 / 5.05 \\
& 5
\end{aligned}
\] & \[
\begin{aligned}
& 4.95 / 5.05 \\
& 5
\end{aligned}
\] & \(\mathrm{V} \min / \mathrm{V}\) max \(\mu \mathrm{A}\) max & \(5 \mathrm{~V} \pm 1 \%\) for Specified Performance \\
\hline \begin{tabular}{l}
DIGITAL INPUTS \\
Input High Voltage, \(\mathrm{V}_{\text {INH }}\) Input Low Voltage, \(\mathrm{V}_{\text {INL }}\) Input Current, \(\mathrm{I}_{\text {IN }}\) Input Capacitance \({ }^{5}\)
\end{tabular} & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 1 \\
& 8
\end{aligned}
\] & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 1 \\
& 8
\end{aligned}
\] & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 1 \\
& 8
\end{aligned}
\] & \begin{tabular}{l}
\(V\) min \\
\(V\) max \\
\(\mu \mathrm{A}\) max \\
pF max
\end{tabular} & \(\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}\) to \(\mathrm{V}_{\mathrm{DD}}\) \\
\hline \begin{tabular}{l}
DIGITAL OUTPUT \\
Serial Data Out (SDO) \\
Output Low Voltage, \(\mathrm{V}_{\mathrm{OL}}\) Output High Voltage, \(\mathrm{V}_{\mathrm{OH}}\)
\end{tabular} & \[
\begin{aligned}
& 0.4 \\
& 4.0
\end{aligned}
\] & \[
\begin{aligned}
& 0.4 \\
& 4.0
\end{aligned}
\] & \[
\begin{aligned}
& 0.4 \\
& 4.0
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{V} \text { max } \\
& \mathrm{V} \text { min }
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{I}_{\text {SINK }}=1.0 \mathrm{~mA} \\
& \mathrm{I}_{\text {SOURCE }}=400 \mu \mathrm{~A}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
ANALOG OUTPUT \\
Output Range Resistor, \(\mathrm{R}_{\mathrm{OFs}}\) Output Voltage Ranges \({ }^{6}\) Output Voltage Ranges \({ }^{6}\) DC Output Impedance
\end{tabular} & \[
\begin{aligned}
& 15 / 30 \\
& +5,+10 \\
& +5,+10, \pm 5 \\
& 0.5
\end{aligned}
\] & \[
\begin{aligned}
& 15 / 30 \\
& +5,+10 \\
& +5,+10, \pm 5 \\
& 0.5
\end{aligned}
\] & \[
\begin{aligned}
& 15 / 30 \\
& +5,+10 \\
& +5,+10, \pm 5 \\
& 0.5
\end{aligned}
\] & \begin{tabular}{l}
\(\mathrm{k} \Omega \min / \max\) \\
V \\
V \\
\(\Omega\) typ
\end{tabular} & \[
\begin{aligned}
& \text { Single Supply; } \mathrm{V}_{\mathrm{ss}}=0 \mathrm{~V} \\
& \text { Dual Supply; } \mathrm{V}_{\mathrm{ss}}=-12 \mathrm{~V} \text { to }-15 \mathrm{~V}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
AC CHARACTERISTICS \(^{5}\) \\
Voltage Output Settling-Time \\
Positive Full-Scale Change \\
Negative Full-Scale Change \\
Negative Full-Scale Change \\
Digital-to-Analog Glitch Impulse \({ }^{3}\) \\
Digital Feedthrough \({ }^{3}\)
\end{tabular} & \[
\begin{aligned}
& 10 \\
& 10 \\
& 10 \\
& 30 \\
& 10
\end{aligned}
\] & \[
\begin{aligned}
& 10 \\
& 10 \\
& 10 \\
& 30 \\
& 10
\end{aligned}
\] & \[
\begin{aligned}
& 12 \\
& 10 \\
& 10 \\
& 30 \\
& 10
\end{aligned}
\] & \begin{tabular}{l}
\(\mu \mathrm{s}\) max \\
\(\mu s\) max \\
\(\mu \mathrm{s}\) typ \\
nV secs typ \\
nV secs typ
\end{tabular} & \begin{tabular}{l}
Settling Time to Within \(\pm 1 / 2\) LSB of Final Value \\
Typically \(3 \mu \mathrm{~s}\) \\
Typically \(5 \mu \mathrm{~S} ; \mathrm{V}_{\mathrm{ss}}=-12 \mathrm{~V}\) to \(-15 \mathrm{~V}^{1}\)
\[
\mathrm{v}_{\mathrm{ss}}=0 \mathrm{~V}
\] \\
DAC Latch Contents Toggled Between All Os and All 1s
\[
\overline{\text { LDAC }}=\mathrm{High}
\]
\end{tabular} \\
\hline \begin{tabular}{l}
POWER REQUIREMENTS \\
\(V_{D D}\) Range \\
\(\mathrm{V}_{\text {ss }}\) Range (Dual Supplies) \(\mathrm{I}_{\mathrm{DD}}\) \\
\(\mathrm{I}_{\text {SS }}\) (Dual Supplies)
\end{tabular} & \[
\begin{aligned}
& +10.8 /+16.5 \\
& -10.8 /-16.5 \\
& 10 \\
& 4
\end{aligned}
\] & \[
\begin{aligned}
& +11.4 /+15.75 \\
& -11.4 /-15.75 \\
& 10 \\
& 4
\end{aligned}
\] & \[
\begin{aligned}
& +11.4 /+15.75 \\
& -11.4 /-15.75 \\
& 12 \\
& 4
\end{aligned}
\] & V min/V max \(\mathrm{V} \min / \mathrm{V}\) max mA max mA max & For Specified Performance Unless Otherwise Stated For Specified Performance Unless Otherwise Stated Output Unloaded; Typically 7 mA Output Unloaded; Typically 2 mA \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Power Supply Tolerance A Version: \(\pm 10 \%\); B, S Versions: \(\pm 5 \%\).
\({ }^{2}\) Temperature Ranges are as follows: A, B Versions: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\); S Version: \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\).
\({ }^{3}\) See terminology.
\({ }^{4}\) Measured with respect to REFIN and includes unipolar/bipolar offset error.
\({ }^{5}\) Sample tested @ \(+25^{\circ} \mathrm{C}\) to ensure compliance.
\({ }^{6} 0\) to +10 V output range is available only with \(\mathrm{V}_{\mathrm{DD}} \geq+14.25 \mathrm{~V}\).
Specifications subject to change without notice.

\begin{tabular}{|c|c|c|c|c|}
\hline Parameter & \begin{tabular}{l}
Limit at \(+25^{\circ} \mathrm{C}\) \\
(All Versions)
\end{tabular} & Limit at \(\mathbf{T}_{\text {min }}, \mathbf{T}_{\text {max }}\) (All Versions) & Units & Conditions/Comments \\
\hline \(\mathrm{t}_{1}{ }^{3}\) & 200 & 200 & ns min & SCLK Cycle Time \\
\hline \(\mathrm{t}_{2}\) & 50 & 50 & \(n \mathrm{nmin}\) & SYNC to SCLK Falling Edge Setup Time \\
\hline \(\mathrm{t}_{3}\) & 120 & 190 & ns min & SYNC to SCLK Hold Time \\
\hline \(\mathrm{t}_{4}\) & 10 & 10 & ns min & Data Setup Time \\
\hline \(\mathrm{t}_{5}\) & 100 & 100 & ns min & Data Hold Time \\
\hline \(\mathrm{t}_{6}\) & 0 & 0 & ns min & \(\overline{\text { SYNC High to LDAC }}\) Low \\
\hline \(\mathrm{t}_{7}\) & 50 & 50 & ns min & LDAC Pulse Width \\
\hline \(\mathrm{t}_{8}\) & 0 & 0 & ns min & \(\overline{\text { LDAC }}\) High to SYNC Low \\
\hline \(\mathrm{t}_{9}\) & 75 & 75 & ns min & CLR Pulse Width \\
\hline \(\mathrm{t}_{10}{ }^{4}\) & 120 & 180 & ns max & SCLK Falling Edge to SDO Valid \\
\hline
\end{tabular}

NOTES
\({ }^{1}\) Sample tested at \(+25^{\circ} \mathrm{C}\) to ensure compliance. All input signals are specified with \(\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%\) to \(90 \%\) of 5 V\()\) and timed from a voltage level of 1.6 V .
\({ }^{2}\) See Figures 7 \& 8.
\({ }^{3}\) SCLK mark/space ratio range is \(40 / 60\) to \(60 / 40\).
\({ }^{4} \mathrm{SDO}\) load capacitance is no greater than 50 pF .

ABSOLUTE MAXIMUM RATINGS \({ }^{\mathbf{1}}\)
( \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) unless otherwise noted)
\(\mathrm{V}_{\mathrm{DD}}\) to AGND, DGND . . . . . . . . . . . . . -0.3 V to +17 V
\(\mathrm{V}_{\text {ss }}\) to AGND, DGND . . . . . . . . . . . . . +0.3 V to -17 V
AGND to DGND . . . . . . . . . . . . -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
\(\mathrm{V}_{\text {OUT }}{ }^{2}\) to AGND . . . . . . . . . . . . . . -6 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
REFOUT to AGND . . . . . . . . . . . . . . . . . . . 0 V to \(\mathrm{V}_{\mathrm{DD}}\)
REFIN to AGND . . . . . . . . . . . . -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
Digital Inputs to DGND . . . . . . . . -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
SDO to DGND . . . . . . . . . . . . . -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
Operating Temperature Range
Industrial (A, B Versions) . . . . . . . . . . . \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
Extended (S Version) . . . . . . . . . . . . . . \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)

Storage Temperature Range . . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Lead Temperature (Soldering, 10 secs) . . . . . . . . . . . \(+300^{\circ} \mathrm{C}\)
Power Dissipation (Any Package) to \(+75^{\circ} \mathrm{C}\). . . . . . 450 mW
Derates above \(+75^{\circ} \mathrm{C}\) by . . . . . . . . . . . . . . . . . . \(6 \mathrm{~mW} /{ }^{\circ} \mathrm{C}\)

\section*{NOTES}
'Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Only one Absolute Maximum Rating may be applied at any time.
\({ }^{2}\) The outputs may be shorted to voltages in this range provided the power dissipation of the package is not exceeded. Short circuit current is typically 80 mA .

\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are inserted.


\section*{ORDERING GUIDE}
\begin{tabular}{l|l|l|l}
\hline Model & Temperature Range & Relative Accuracy & Package Option \({ }^{\mathbf{1}}\) \\
\hline AD7243AN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\mathrm{N}-16\) \\
AD7243BN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\mathrm{N}-16\) \\
AD7243AR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\mathrm{R}-16\) \\
AD7243BR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\mathrm{R}-16\) \\
AD7243AQ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & Q-16 \\
AD7243BQ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & Q-16 \\
AD7243SQ \({ }^{2}\) & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & Q-16 \\
\hline
\end{tabular}

\footnotetext{
NOTES
\({ }^{1} \mathrm{~N}=\) Plastic DIP; \(\mathrm{R}=\) SOIC; \(\mathrm{Q}=\) Cerdip. For outline information see Package Information section.
\({ }^{2}\) Available to \(/ 883 \mathrm{~B}\) processing only. Contact your local sales office for military data sheet.
}

PIN FUNCTION DESCRIPTION (DIP \& SOIC PIN NUMBERS)
\begin{tabular}{|c|c|c|}
\hline Pin & Mnemonic & Description \\
\hline 1 & REFIN & Voltage Reference Input. It is internally buffered before being applied to the DAC. The nominal reference voltage for specified operation of the AD7243 is 5 V . \\
\hline 2 & REFOUT & Voltage Reference Output. The internal 5 V analog reference is provided at this pin. To operate the part using its internal reference, REFOUT should be connected to REFIN. \\
\hline 3 & \(\overline{\text { CLR }}\) & Clear, Logic Input. Taking this input low sets \(\mathrm{V}_{\text {OUt }}\) to 0 V in both unipolar ranges and the 2 s complement bipolar range and to -REFIN in the offset binary bipolar range. \\
\hline 4 & \(\overline{\text { BIN }} / \mathrm{COMP}\) & Logic Input. This input selects the data format to be either binary or 2 s complement. In both unipolar ranges, natural binary format is selected by connecting this input to a logic " 0 ." In the bipolar configuration, offset binary format is selected with a logic " 0 " while a logic " 1 " selects 2 s complement format. \\
\hline 5 & SCLK & Serial Clock, Logic Input. Data is clocked into the input register on each falling SCLK edge. \\
\hline 6 & SDIN & Serial Data In, Logic Input. The 16-bit serial data word is applied to this input. \\
\hline 7 & \(\overline{\text { SYNC }}\) & Data Synchronization Pulse, Logic Input. Taking this input low initializes the internal logic in readiness for a new data word. \\
\hline 8 & DGND & Digital Ground. Ground reference for all digital circuitry. \\
\hline 9 & \(\overline{\text { LDAC }}\) & Load DAC, Logic Input. Updates the DAC output. The DAC output is updated on the falling edge of this signal or alternatively if this line is permanently low, an automatic update mode is selected whereby the DAC is updated on the 16th falling SCLK pulse. \\
\hline 10 & DCEN & Daisy-Chain Enable, Logic Input. Connect this pin high if a daisy-chain interface is being used, otherwise this pin must be connected low. \\
\hline 11 & SDO & Serial Data Out, Logic Output. With DCEN at Logic " 1 " this output is enabled, and the serial data in the input shift register is clocked out on each falling SCLK edge. \\
\hline 12 & AGND & Analog Ground. Ground reference for all analog circuitry. \\
\hline 13 & \(\mathrm{R}_{\text {OFS }}\) & Output Offset Resistor for the amplifier. It is connected to \(\mathrm{V}_{\mathrm{OUT}}\) for the +5 V range, to AGND for the +10 V range and to REFIN for the -5 V to +5 V range. \\
\hline 14 & \(\mathrm{V}_{\text {OUT }}\) & Analog Output Voltage. This is the buffer amplifier output voltage. Three different output voltage ranges can be chosen: 0 to \(+5 \mathrm{~V}, 0\) to +10 V and -5 V to +5 V . \\
\hline 15 & \(\mathrm{V}_{\text {ss }}\) & Negative Power Supply (used for the output amplifier only, may be connected to 0 V for single supply operation or to -12 V to -15 V for dual supplies). \\
\hline 16 & \(\mathrm{V}_{\mathrm{DD}}\) & Positive Power Supply ( +12 V to +15 V ). \\
\hline
\end{tabular}

\section*{PIN CONFIGURATION \\ DIP and SOIC}


\section*{FEATURES}

\author{
12-Bit CMOS DAC with Output Amplifier and Reference \\ Improved AD7245/AD7248: \\ 12 V to 15 V Operation \(\pm 1 / 2\) LSB Linearity Grade Faster Interface-30 ns typ Data Setup Time Extended Plastic Temperature Range ( \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) ) \\ Single or Dual Supply Operation \\ Low Power-65 mW typ in Single Supply \\ Parallel Loading Structure: AD7245A \\ (8+4) Loading Structure: AD7248A
}

\section*{GENERAL DESCRIPTION}

The AD7245A/AD7248A is an enhanced version of the industry standard AD7245/AD7248. Improvements include operation from 12 V to 15 V supplies, a \(\pm 1 / 2\) LSB linearity grade, faster interface times and better full scale and reference variations with \(\mathrm{V}_{\mathrm{DD}}\). Additional features include extended temperature range operation for commercial and industrial grades.
The AD7245A/AD7248A is a complete, 12-bit, voltage output, digital-to-analog converter with output amplifier and Zener voltage reference on a monolithic CMOS chip. No external user trims are required to achieve full specified performance.
Both parts are microprocessor compatible, with high speed data latches and double-buffered interface logic. The AD7245A accepts 12 -bit parallel data which is loaded into the input latch on the rising edge of \(\overline{\mathrm{CS}}\) or \(\overline{\mathrm{WR}}\). The AD7248A has an 8 -bit wide data bus with data loaded to the input latch in two write operations. For both parts, an asynchronous \(\overline{\text { LDAC }}\) signal transfers data from the input latch to the DAC latch and updates the analog output. The AD7245A also has a \(\overline{C L R}\) signal on the DAC latch which allows features such as power-on reset to be implemented.
The on-chip 5 V buried Zener diode provides a low noise, temperature compensated reference for the DAC. For single supply operation, two output ranges of 0 to +5 V and 0 to +10 V are available, while these two ranges plus an additional \(\pm 5 \mathrm{~V}\) range are available with dual supplies. The output amplifiers are capable of developing +10 V across a \(2 \mathrm{k} \Omega\) load to GND.
The AD7245A/AD7248A is fabricated in linear compatible CMOS ( LC \(^{2}\) MOS), an advanced, mixed technology process that combines precision bipolar circuits with low power CMOS logic. The AD7245A is available in a small, \(0.3^{\prime \prime}\) wide, 24 -pin DIP and SOIC and in 28 -terminal surface mount packages. The AD7248A is packaged in a small, \(0.3^{\prime \prime}\) wide, 20-pin DIP and SOIC and in 20-terminal surface mount packages.

AD7245A FUNCTIONAL BLOCK DIAGRAM

\section*{AD7248A FUNCTIONAL BLOCK DIAGRAM}

\section*{PRODUCT HIGHLIGHTS}
1. The AD7245A/AD7248A is a 12 -bit DACPORT \({ }^{\circledR}\) on a single chip. This single chip design and small package size offer considerable space saving and increased reliability over multichip designs.
2. The improved interface times on the part allows easy, direct interfacing to most modern microprocessors.
3. The AD7245A/AD7248A features a wide power supply range allowing operation from 12 V supplies.



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AGND \(=\operatorname{DGND}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}\). All specifications \(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) unless otherwise noted.)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Parameter & \(\mathrm{A}^{2}\) Version & \[
\begin{array}{|l|}
\hline \mathbf{B}^{2} \\
\mathbf{V} \text { ersion }
\end{array}
\] & \[
\begin{array}{|l}
\mathbf{T}^{2} \\
\mathbf{V} \text { ersion }
\end{array}
\] & Units & Test Conditions/Comments \\
\hline \begin{tabular}{l}
STATIC PERFORMANCE \\
Resolution \\
Relative Accuracy @ \(+25^{\circ} \mathrm{C}^{3}\) \\
\(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) \\
\(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) \\
Differential Nonlinearity \({ }^{3}\) \\
Unipolar Offset Error @ \(+25^{\circ} \mathrm{C}^{3}\) \\
\(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) \\
Bipolar Zero Error @ \(+25^{\circ} \mathrm{C}^{3}\) \\
\(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) \\
DAC Gain Error \({ }^{3,6}\) \\
Full-Scale Output Voltage Error \({ }^{7}\) @ \(+25^{\circ} \mathrm{C}\) \(\Delta\) Full Scale \(/ \Delta V_{D D}\) \(\Delta\) Full Scale \(/ \Delta V_{\text {ss }}\) \\
Full-Scale Temperature Coefficient \({ }^{8}\)
\end{tabular} & \[
\begin{aligned}
& 12 \\
& \pm 3 / 4 \\
& \pm 1 \\
& \\
& \pm 1 \\
& \pm 3 \\
& \pm 5 \\
& \pm 3 \\
& \pm 5 \\
& \pm 2 \\
& \pm 0.2 \\
& \pm 0.06 \\
& \pm 0.01 \\
& \pm 30
\end{aligned}
\] & \[
\begin{aligned}
& 12 \\
& \pm 1 / 2 \\
& \pm 3 / 4 \\
& \pm 1 / 2 \\
& \pm 1 \\
& \pm 3 \\
& \pm 5 \\
& \pm 2 \\
& \pm 4 \\
& \pm 2 \\
& \pm 0.2 \\
& \pm 0.06 \\
& \pm 0.01 \\
& \pm 30
\end{aligned}
\] & \[
\begin{aligned}
& 12 \\
& \pm 1 / 2 \\
& \pm 3 / 4 \\
& \\
& \pm 1 \\
& \pm 3 \\
& \pm 5 \\
& \pm 2 \\
& \pm 4 \\
& \pm 2 \\
& \pm 0.2 \\
& \pm 0.06 \\
& \pm 0.01 \\
& \pm 40
\end{aligned}
\] & \begin{tabular}{l}
Bits \\
LSB max \\
LSB max \\
LSB max \\
LSB max \\
LSB max \\
LSB max \\
LSB max \\
LSB max \\
LSB max \\
\% of FSR max \\
\(\%\) of FSR/V max \\
\(\%\) of FSR/V max \\
ppm of FSR \(/{ }^{\circ} \mathrm{C}\) max
\end{tabular} & \begin{tabular}{l}
\[
V_{D D}=15 \mathrm{~V} \pm 5 \%
\] \\
Guaranteed Monotonic
\[
\mathrm{V}_{\mathrm{ss}}=0 \mathrm{~V} \text { or }-12 \mathrm{~V} \text { to }-15 \mathrm{~V}^{4}
\] \\
Typical Tempco is \(\pm 3 \mathrm{ppm}\) of \(\mathrm{FSR}^{5} /{ }^{\circ} \mathrm{C}\). \\
\(\mathrm{R}_{\mathrm{OFS}}\) connected to REF OUT; \(\mathrm{V}_{\text {SS }}=-12 \mathrm{~V}\) to \(-15 \mathrm{~V}^{4}\) \\
Typical Tempco is \(\pm 3 \mathrm{ppm}\) of \(\mathrm{FSR}^{5} /{ }^{\circ} \mathrm{C}\).
\[
\begin{aligned}
& \mathrm{V}_{\mathrm{DD}}=+15 \mathrm{~V} \\
& \mathrm{~V}_{\mathrm{DD}}=+12 \mathrm{~V} \text { to }+15 \mathrm{~V}^{4} \\
& \mathrm{~V}_{\mathrm{SS}}=-12 \mathrm{~V} \text { to }-15 \mathrm{~V}^{4} \\
& \mathrm{~V}_{\mathrm{DD}}=+15 \mathrm{~V}
\end{aligned}
\]
\end{tabular} \\
\hline \begin{tabular}{l}
REFERENCE OUTPUT \\
REF OUT @ \(+25^{\circ} \mathrm{C}\) \\
\(\Delta\) REF OUT/ \(\Delta V_{D D}\) \\
Reference Temperature Coefficient Reference Load Change ( \(\Delta\) REF OUT vs. \(\Delta \mathrm{I}\) )
\end{tabular} & \[
\left|\begin{array}{l}
4.99 / 5.01 \\
2 \\
\pm 25 \\
-1
\end{array}\right|
\] & \[
\begin{aligned}
& 4.99 / 5.01 \\
& 2 \\
& \pm 25 \\
& -1
\end{aligned}
\] & \[
\begin{aligned}
& 4.99 / 5.01 \\
& 2 \\
& \pm 35 \\
& -1
\end{aligned}
\] & \(\mathrm{V} \min / \mathrm{V}\) max \(\mathrm{mV} / \mathrm{V}\) max ppm \(/{ }^{\circ} \mathrm{C}\) typ mV max & \begin{tabular}{l}
\[
\begin{aligned}
& \mathrm{V}_{\mathrm{DD}}=+15 \mathrm{~V} \\
& \mathrm{~V}_{\mathrm{DD}}=+12 \mathrm{~V} \text { to }+15 \mathrm{~V}^{4}
\end{aligned}
\] \\
Reference Load Current Change ( \(0-100 \mu \mathrm{~A}\) )
\end{tabular} \\
\hline \begin{tabular}{l}
DIGITAL INPUTS \\
Input High Voltage, \(\mathrm{V}_{\text {INH }}\) Input Low Voltage, \(\mathrm{V}_{\text {INL }}\) Input Current, \(\mathrm{I}_{\mathrm{IN}}\) Input Capacitance \({ }^{9}\)
\end{tabular} & \[
\begin{array}{|l}
2.4 \\
0.8 \\
\pm 10 \\
8
\end{array}
\] & \[
\begin{array}{|l}
2.4 \\
0.8 \\
\pm 10 \\
8
\end{array}
\] & \[
\begin{array}{|l}
2.4 \\
0.8 \\
\pm 10 \\
8
\end{array}
\] & V min \(V\) max \(\mu \mathrm{A}\) max pF max & \(\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}\) to \(\mathrm{V}_{\mathrm{DD}}\) \\
\hline \begin{tabular}{l}
ANALOG OUTPUTS \\
Output Range Resistors Output Voltage Ranges \({ }^{10}\) Output Voltage Ranges \({ }^{10}\) DC Output Impedance
\end{tabular} & \[
\left|\begin{array}{l}
15 / 30 \\
+5,+10 \\
+5,+10, \\
\pm 5 \\
0.5
\end{array}\right|
\] & \[
\begin{aligned}
& 15 / 30 \\
& +5,+10 \\
& +5,+10, \\
& \pm 5 \\
& 0.5
\end{aligned}
\] & \[
\begin{aligned}
& 15 / 30 \\
& +5,+10 \\
& +5,+10, \\
& \pm 5 \\
& 0.5
\end{aligned}
\] & \begin{tabular}{l}
\(\mathrm{k} \Omega \min / \mathrm{k} \Omega\) max \\
V \\
V \\
\(\Omega\) typ
\end{tabular} & \begin{tabular}{l}
\(\mathrm{V}_{\mathrm{ss}}=0 \mathrm{~V}\); Pin Strappable \\
\(\mathrm{V}_{\mathrm{ss}}=-12 \mathrm{~V}\) to \(-15 \mathrm{~V} ;{ }^{4}\) Pin Strappable
\end{tabular} \\
\hline AC CHARACTERISTICS \({ }^{9}\) Voltage Output Settling Time Positive Full-Scale Change Negative Full-Scale Change Output Voltage Slew Rate Digital Feedthrough \({ }^{3}\) Digital-to-Analog Glitch Impulse & 10
30 & 2
10
30 & \[
\begin{aligned}
& 10 \\
& 10 \\
& 1.5 \\
& 10 \\
& 30
\end{aligned}
\] & us max \(\mu s \max\) \(\mathrm{V} / \mu \mathrm{s} \min\) nV-s typ nV-s typ & Settling Time to Within \(\pm 1 / 2\) LSB of Final Value DAC Latch All 0 s to All 1 s DAC Latch All 1s to All 0s; \(\mathrm{V}_{\mathrm{ss}}=-12 \mathrm{~V}\) to \(-15 \mathrm{~V}^{4}\) \\
\hline \begin{tabular}{l}
POWER REQUIREMENTS \\
\(V_{D D}\) \\
\(\mathrm{V}_{\text {ss }}\) \\
\(\mathrm{I}_{\mathrm{DD}} @+25^{\circ} \mathrm{C}\) \\
\(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) \\
\(\mathrm{I}_{\text {SS }}\) (Dual Supplies)
\end{tabular} & \[
\begin{aligned}
& +10.8 / \\
& +16.5 \\
& -10.8 / \\
& -16.5 \\
& 9 \\
& 10 \\
& 3 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& +11.4 / \\
& +15.75 \\
& -11.4 / \\
& -15.75 \\
& 9 \\
& 10 \\
& 3 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& +11.4 / \\
& +15.75 \\
& -11.4 / \\
& -15.75 \\
& 9 \\
& 12 \\
& 5
\end{aligned}
\] & \begin{tabular}{l}
V min/ \\
\(\mathrm{V} \min /\) \\
\(V_{\text {max }}\) mA max mA max mA max
\end{tabular} & \begin{tabular}{l}
For Specified Performance Unless Otherwise Stated \\
For Specified Performance Unless Otherwise Stated \\
Output Unloaded; Typically 5 mA \\
Output Unloaded \\
Output Unloaded; Typically 2 mA
\end{tabular} \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Power supply tolerance is \(\pm 10 \%\) for A Version and \(\pm 5 \%\) for B and T Versions.
\({ }^{2}\) Temperature ranges are as follows: \(\mathrm{A} / \mathrm{B}\) Versions; \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\); T Version; \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\).
\({ }^{3}\) See Terminology.
\({ }^{4}\) With appropriate power supply tolerances.
\({ }^{5}\) FSR means Full-Scale Range and is 5 V for the 0 to +5 V output range and 10 V for both the 0 to +10 V and \(\pm 5 \mathrm{~V}\) output ranges.
\({ }^{6}\) This error is calculated with respect to the reference voltage and is measured after the offset error has been allowed for.
\({ }^{7}\) This error is calculated with respect to an ideal 4.9988 V on the 0 to +5 V and \(\pm 5 \mathrm{~V}\) ranges; it is calculated with respect to an ideal 9.9976 V on the 0 to +10 V range. It includes the effects of internal voltage reference, gain and offset errors.
\({ }^{8}\) Full-Scale TC \(=\Delta \mathrm{FS} / \Delta \mathrm{T}\), where \(\Delta \mathrm{FS}\) is the full-scale change from \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) to \(\mathrm{T}_{\text {MIN }}\) or \(\mathrm{T}_{\text {MAX }}\).
\({ }^{9}\) Sample tested at \(+25^{\circ} \mathrm{C}\) to ensure compliance.
\({ }^{10} 0\) to +10 V output range is available only when \(\mathrm{V}_{\mathrm{DD}} \geq+14.25 \mathrm{~V}\).
Specifications subject to change without notice.

SWITCHING CHARACTERISTICS \({ }^{1}\)
\(\left(V_{D D}=+12 V\right.\) to \(+15 V_{i}{ }^{2} V_{S S}=0 V\) or \(-12 V\) to \(-15 V_{i}^{2}\) See Figures 5 and 7.)
\begin{tabular}{|c|c|c|c|c|}
\hline Parameter & A, B Versions & S Version & Units & Conditions \\
\hline \[
\begin{gathered}
\mathrm{t}_{1} @_{1}+25^{\circ} \mathrm{C} \\
\mathrm{~T}_{\text {min }} \text { to } \mathrm{T}_{\text {max }}
\end{gathered}
\] & \[
\begin{aligned}
& 55 \\
& 80
\end{aligned}
\] & \[
\begin{aligned}
& 55 \\
& 100
\end{aligned}
\] & \[
\begin{aligned}
& \text { ns typ } \\
& \text { ns min }
\end{aligned}
\] & Chip Select Pulse Width \\
\hline \[
\begin{aligned}
& \mathrm{t}_{2} @+25^{\circ} \mathrm{C} \\
& \mathrm{~T}_{\text {min }} \text { to } \mathrm{T}_{\text {max }}
\end{aligned}
\] & \[
\begin{aligned}
& 40 \\
& 80
\end{aligned}
\] & \[
\begin{aligned}
& 40 \\
& 100
\end{aligned}
\] & \[
\begin{aligned}
& \text { ns typ } \\
& \text { ns min }
\end{aligned}
\] & Write Pulse Width \\
\hline \[
\begin{aligned}
& \mathrm{t}_{3} @+25^{\circ} \mathrm{C} \\
& \mathrm{~T}_{\text {min }} \text { to } \mathrm{T}_{\text {max }}
\end{aligned}
\] & \[
\begin{aligned}
& 0 \\
& 0
\end{aligned}
\] & \[
\begin{aligned}
& 0 \\
& 0
\end{aligned}
\] & \[
\begin{aligned}
& \text { ns } \min \\
& \text { ns } \min
\end{aligned}
\] & Chip Select to Write Setup Time \\
\hline \[
\begin{aligned}
& \mathrm{t}_{4} @+25^{\circ} \mathrm{C} \\
& \mathrm{~T}_{\text {min }} \text { to } \mathrm{T}_{\text {max }} \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 0 \\
& 0
\end{aligned}
\] & \[
\begin{aligned}
& 0 \\
& 0
\end{aligned}
\] & \[
\begin{aligned}
& \text { ns } \min \\
& \text { ns } \min
\end{aligned}
\] & Chip Select to Write Hold Time \\
\hline \[
\begin{aligned}
& \text { t. } \mathrm{t}_{5} @+25^{\circ} \mathrm{C} \\
& \mathrm{~T}_{\text {min }} \text { to } \mathrm{T}_{\text {max }} \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 40 \\
& 80 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 40 \\
& 80 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \text { ns typ } \\
& \text { ns min }
\end{aligned}
\] & Data Valid to Write Setup Time \\
\hline \[
\begin{aligned}
& \mathrm{t}_{6} @+25^{\circ} \mathrm{C} \\
& \mathrm{~T}_{\text {min }} \text { to } \mathrm{T}_{\text {max }} \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 10 \\
& 10 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 10 \\
& 10 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \text { ns } \min \\
& \text { ns } \min
\end{aligned}
\] & Data Valid to Write Hold Time \\
\hline \[
\begin{aligned}
& \mathrm{t}_{7} @+25^{\circ} \mathrm{C} \\
& \mathrm{~T}_{\text {min }} \mathrm{to}_{\text {max }} \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 40 \\
& 80 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 40 \\
& 100 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \text { ns typ } \\
& \text { ns min }
\end{aligned}
\] & Load DAC Pulse Width \\
\hline \[
\begin{aligned}
& \mathrm{t}_{8} @+25^{\circ} \mathrm{C} \\
& \mathrm{~T}_{\text {min }} \text { to } \mathrm{T}_{\text {max }}
\end{aligned}
\] & \[
\begin{aligned}
& 40 \\
& 80 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 40 \\
& 100 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \text { ns typ } \\
& \text { ns min } \\
& \hline
\end{aligned}
\] & Clear Pulse Width \\
\hline
\end{tabular}

\section*{NOTE}
\({ }^{1}\) Sample tested at \(+25^{\circ} \mathrm{C}\) to ensure compliance.
\({ }^{2}\) Power supply tolerance is \(\pm 10 \%\) for A Version and \(\pm 5 \%\) for B and S Versions.

\section*{ABSOLUTE MAXIMUM RATINGS*}


Operating Temperature
Commercial (A, B Versions) . . . . . . . . . . . \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
Extended (S Version) . . . . . . . . . . . . . . \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
Storage Temperature . . . . . . . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Lead Temperature (Soldering, 10 secs) . . . . . . . . . . \(+300^{\circ} \mathrm{C}\)

\section*{NOTE}
\({ }^{1}\) The output may be shorted to voltages in this range provided the power dissipation of the package is not exceeded. \(\mathrm{V}_{\text {Otr }}\) short circuit current is typically 80 mA .
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are inserted.


\section*{AD7245A ORDERING GUIDE}
\begin{tabular}{l|l|l|l}
\hline Model \(^{1}\) & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Relative \\
Accuracy
\end{tabular} & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD7245AAN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 3 / 4 \mathrm{LSB}\) & \(\mathrm{N}-24\) \\
AD7245ABN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\mathrm{N}-24\) \\
AD7245AAQ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 3 / 4 \mathrm{LSB}\) & \(\mathrm{Q}-24\) \\
AD7245ATQ \({ }^{3}\) & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 3 / 4 \mathrm{LSB}\) & \(\mathrm{Q}-24\) \\
AD7245AAP & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 3 / 4 \mathrm{LSB}\) & \(\mathrm{P}-28 \mathrm{~A}\) \\
AD7245AAR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 3 / 4 \mathrm{LSB}\) & \(\mathrm{R}-24\) \\
AD7245ABR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\mathrm{R}-24\) \\
AD7245ATE \(^{3}\) & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 3 / 4 \mathrm{LSB}\) & \(\mathrm{E}-28 \mathrm{~A}\) \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) To order MIL-STD-883, Class B, processed parts, add /883B to part number. Contact our local sales office for military data sheet and availability.
\({ }^{2} \mathrm{E}=\) Leadless Ceramic Chip Carrier; \(\mathrm{N}=\) Plastic DIP; P = Plastic Leaded Chip Carrier; \(\mathrm{Q}=\) Cerdip; \(\mathrm{R}=\) SOIC. For outline information see Package Information section.
\({ }^{3}\) This grade will be available to /883B processing only.
AD7248A ORDERING GUIDE
\begin{tabular}{l|l|l|l}
\hline Model \(^{\mathbf{1}}\) & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Relative \\
Accuracy
\end{tabular} & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD7248AAN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 3 / 4 \mathrm{LSB}\) & \(\mathrm{N}-20\) \\
AD7248ABN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\mathrm{N}-20\) \\
AD7248AAQ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 3 / 4 \mathrm{LSB}\) & \(\mathrm{Q}-20\) \\
AD7248ATQ \({ }^{3}\) & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 3 / 4 \mathrm{LSB}\) & \(\mathrm{Q}-20\) \\
AD7248AAP & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 3 / 4 \mathrm{LSB}\) & \(\mathrm{P}-20 \mathrm{~A}\) \\
AD7248AAR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 3 / 4 \mathrm{LSB}\) & \(\mathrm{R}-20\) \\
AD7248ABR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\mathrm{R}-20\) \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) To order MIL-STD-883, Class B, processed parts, add /883B to part number. Contact our local sales office for military data sheet and availability.
\({ }^{2} \mathrm{~N}=\) Plastic DIP; \(\mathrm{P}=\) Plastic Leaded Chip Carrier; \(\mathrm{Q}=\) Cerdip; \(\mathrm{R}=\) SOIC. For outline information see Package Information section.
\({ }^{3}\) This grade will be available to \(/ 883 \mathrm{~B}\) processing only.

\section*{TERMINOLOGY}

\section*{RELATIVE ACCURACY}

Relative Accuracy, or end-point nonlinearity, is a measure of the actual deviation from a straight line passing through the endpoints of the DAC transfer function. It is measured after allowing for zero and full scale and is normally expressed in LSBs or as a percentage of full-scale reading.

\section*{DIFFERENTIAL NONLINEARITY}

Differential Nonlinearity is the difference between the measured change and the ideal 1 LSB change between any two adjacent codes. A specified differential nonlinearity of \(\pm 1\) LSB max over the operating temperature range ensures monotonicity.

\section*{DIGITAL FEEDTHROUGH}

Digital Feedthrough is the glitch impulse injected from the digital inputs to the analog output when the inputs change state. It is measured with \(\overline{\mathrm{LDAC}}\) high and is specified in nV -s.

\section*{DAC GAIN ERROR}

DAC Gain Error is a measure of the output error between an ideal DAC and the actual device output with all 1 s loaded after offset error has been allowed for. It is, therefore defined as:

\section*{Measured Value-Offset-Ideal Value}
where the ideal value is calculated relative to the actual reference value.

\section*{UNIPOLAR OFFSET ERROR}

Unipolar Offset Error is a combination of the offset errors of the voltage mode DAC and the output amplifier and is measured when the part is configured for unipolar outputs. It is present or all codes and is measured with all 0 s in the DAC register.

\section*{BIPOLAR ZERO OFFSET ERROR}

Bipolar Zero Offset Error is measured when the part is configured for bipolar output and is a combination of errors from the DAC and output amplifier. It is present for all codes and is measured with a code of 2048 (decimal) in the DAC register.

\section*{SINGLE SUPPLY LINEARITY AND GAIN ERROR}

The output amplifier of the AD7245A/AD7248A can have a true negative offset even when the part is operated from a single positive power supply. However, because the lower supply rail to the part is 0 V , the output voltage cannot actually go negative. Instead the output voltage sits on the lower rail and this results in the transfer function shown across. This is an offset effect and the transfer function would have followed the dotted line if the output voltage could have gone negative. Normally, linearity is measured after offset and full scale have been adjusted or allowed for. On the AD7245A/AD7248A the negative offset is allowed for by calculating the linearity from the code which the amplifier comes off the lower rail. This code is given by the negative offset specification. For example, the single supply linearity specification applies between Code 3 and Code 4095 for the \(25^{\circ} \mathrm{C}\) specification and between Code 5 and Code 4095 over the \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) temperature range. Since gain error is also measured after offset has been allowed for, it is calculated between the same codes as the linearity error. Bipolar linearity and gain error are measured between Code 0 and Code 4095.


\section*{AD7245A PIN FUNCTION DESCRIPTION \\ (DIP PIN NUMBERS)}
\begin{tabular}{|c|c|c|c|c|c|}
\hline Pin & Mnemonic & Description & Pin & Mnemonic & Description \\
\hline 1 & \(\mathrm{V}_{\text {ss }}\) & Negative Supply Voltage (0 V for single supply operation). & 19 & \(\overline{\mathrm{WR}}\) & Write Input (Active LOW). This is used in conjunction with \(\overline{\mathrm{CS}}\) to write data into the input latch of the AD7245A. \\
\hline 2 & \(\mathrm{R}_{\text {OFS }}\) & Bipolar Offset Resistor. This provides access to the on-chip application resistors and allows different output voltage ranges. & 20 & \(\overline{\text { LDAC }}\) & \multirow[t]{2}{*}{Load DAC Input (Active LOW). This is an asynchronous input which when active transfers data from the input latch to the DAC latch.} \\
\hline 3 & REF OUT & Reference Output. The on-chip reference is provided at this pin and is used when configuring the part for bipolar outputs. & 21 & \(\overline{\text { CLR }}\) & \\
\hline 4 & AGND & Analog Ground. & & & Clear Input (Active LOW). When this input is active the contents of the DAC latch are reset to all 0 s . \\
\hline 5 & DB11 & Data Bit 11. Most Significant Bit (MSB). & 22 & \(\mathrm{V}_{\mathrm{D}}\) & Positive Supply Voltage. \\
\hline 6-11 & DB10-DB5 & Data Bit 10 to Data Bit 5. & 23 & & \\
\hline 12 & DGND & Digital Ground. & 23 & \(\mathrm{R}_{\mathrm{FB}}\) & the amplifier's feedback loop. \\
\hline 13-16 & DB4-DB1 & Data Bit 4 to Data Bit 1. & 24 & \(\mathrm{V}_{\text {OUT }}\) & Output Voltage. Three different output \\
\hline 17 & DB0 & Data Bit 0. Least Significant Bit (LSB). & & & voltage ranges can be chosen: 0 to +5 V , \\
\hline 18 & \(\overline{\mathrm{CS}}\) & Chip Select Input (Active LOW). The device & & & 0 to +10 V or -5 V to +5 V . \\
\hline
\end{tabular}

\section*{AD7245A PIN CONFIGURATIONS}


\section*{AD7248A PIN FUNCTION DESCRIPTION}
(ANY PACKAGE)
\begin{tabular}{cll}
\hline Pin & Mnemonic & Description \\
\hline 1 & V \(_{\text {Ss }}\) & \begin{tabular}{l} 
Negative Supply Voltage (0 V for single \\
supply operation).
\end{tabular} \\
2 & R \(_{\text {OFs }}\) & \begin{tabular}{l} 
Bipolar Offset Resistor. This provides \\
access to the on-chip application resistors \\
and allows different output voltage ranges.
\end{tabular} \\
3 & REF OUT & \begin{tabular}{l} 
Reference Output. The on-chip reference is \\
provided at this pin and is used when \\
configuring the part for bipolar outputs.
\end{tabular} \\
& & Analog Ground. \\
4 & AGND & Data Bit 7. \\
5 & DB7 & Data Bit 6. \\
6 & DB6 & Data Bit 5. \\
7 & DB5 & Data Bit 4. \\
8 & DB4 & Data Bit 3/Data Bit 11 (MSB). \\
9 & DB3 & Digital Ground. \\
10 & DGND & Data Bit 2/Data Bit 10. \\
11 & DB2 & Data Bit 1/Data Bit 9. \\
12 & DB1 & Data Bit 0 (LSB)/Data Bit 8. \\
\hline
\end{tabular}
\(\left.\begin{array}{lll}\hline \text { Pin } & \text { Mnemonic } & \text { Description } \\
\hline 14 & \overline{\mathrm{CSMSB}} & \begin{array}{l}\text { Chip Select Input for MS Nibble. (Active } \\
\text { LOW). This selects the upper 4 bits of the } \\
\text { input latch. Input data is right justified. } \\
\text { Chip Select Input for LS byte. (Active } \\
\text { LOW). This selects the lower } 8 \text { bits of the } \\
\text { input latch. }\end{array} \\
16 & \overline{\mathrm{CSLSB}} & \overline{\mathrm{WR}}\end{array} \begin{array}{l}\text { Write Input This is used in conjunction } \\
\text { with } \overline{\mathrm{CSMSB}} \text { and } \overline{\text { tSLSB to load data into }}\end{array}\right\}\)\begin{tabular}{l} 
the input latch of the AD7248A.
\end{tabular}

\section*{AD7248A PIN CONFIGURATIONS}

DIP and SOIC


LCCC


PLCC


FEATURES
Two 12-Bit CMOS DAC Channels with On-Chip Voltage Reference Output Amplifiers
Three Selectable Output Ranges per Channel -5 V to \(+5 \mathrm{~V}, 0\) to \(+5 \mathrm{~V}, 0\) to +10 V

\section*{Serial Interface}

125 kHz DAC Update Rate
Small Size : 16-Pin DIP or SOIC
Low Power Dissipation

\section*{APPLICATIONS}

Process Control Industrial Automation
Digital Signal Processing Systems Input/Output Ports

\section*{GENERAL DESCRIPTION}

The AD7249 contains a pair of 12-bit, voltage-output, digital-toanalog converters with output amplifiers and Zener voltage reference on a monolithic CMOS chip. No external trims are required to achieve full specified performance.
The output amplifiers are capable of developing +10 V across a \(2 \mathrm{k} \Omega\) load. The output voltage ranges with single supply operation are 0 V to +5 V or 0 V to +10 V , while an additional bipolar \(\pm 5 \mathrm{~V}\) output range is available with dual supplies. The ranges are selected using the internal gain resistor.
Interfacing to the AD7249 is serial, minimizing pin count and allowing a small package size. Standard control signals allow interfacing to most DSP processors and microcontrollers. The data stream consists of 16 bits, DB15 to DB13 are don't care bits, the 13th bit (DB12) is used as the channel select bit and the remaining 12 bits (DB11 to DB0) contain the data to update the DAC. The 16 -bit data word is clocked into the input register on each falling SCLK edge.
The data format is natural binary in both unipolar ranges, while either offset binary or twos complement format may be selected in the bipolar range. A \(\overline{\text { CLR }}\) function is provided which sets the output to 0 V in both unipolar ranges and in the twos complement bipolar range, while with offset binary data format, the output is set to -REFIN. This function is useful as a power-on reset as it allows the outputs to be set to a known voltage level.

DACPORT is a registered trademark of Analog Devices, Inc.

FUNCTIONAL BLOCK DIAGRAM


The AD7249 features a serial interface which allows easy connection to both microcomputers and 16 -bit digital signal processors with serial ports. The serial data may be applied at rates up to 2 MHz allowing a DAC update rate of 125 kHz .

The AD7249 is fabricated on linear compatible CMOS ( \(\mathrm{LC}^{2} \mathrm{MOS}\) ), an advanced, mixed technology process. It is packaged in 16-pin DIP and 16-pin SOIC packages.

\section*{PRODUCT HIGHLIGHTS}
1. Two complete 12 -bit DACPORTs \({ }^{\circledR}\)

The AD7249 contains two complete voltage output, 12-bit DACs in both 16 -lead DIP and SOIC packages.
2. Single or dual supply operation
3. Minimum 3-wire interface to most DSP processors
4. DAC update rate -125 kHz

AD7249 - SPECIFICATIONS \({ }_{\left(v_{D 0}=+12 v\right.}\) to \(+15 v,{ }^{1} v_{S s}=0 v\) or \(-12 v\) to \(-15 v,{ }^{1}\) AGND \(=\) DGND \(=\) O V, REFIN \(=+5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=\mathbf{2 k \Omega}, \mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}\) to AGND All specifications \(\mathrm{T}_{\text {mIN }}\) to \(\mathrm{T}_{\text {max }}\) unless otherwise noted.)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Parameter & A Version \({ }^{2}\) & B Version \({ }^{2}\) & S Version \({ }^{2}\) & Units & Test Conditions/Comments \\
\hline \begin{tabular}{l}
STATIC PERFORMANCE \\
Resolution \\
Relative Accuracy \({ }^{3}\) \\
Differential Nonlinearity \({ }^{3}\) \\
Unipolar Offset Error \({ }^{3}\) \\
Bipolar Zero Error \({ }^{3}\) \\
Full-Scale Error \({ }^{3,4}\) \\
Full-Scale Temperature Coefficient
\end{tabular} & \[
\begin{aligned}
& 12 \\
& \pm 1 \\
& \pm 0.9 \\
& \pm 5 \\
& \\
& \pm 6 \\
& \\
& \pm 6 \\
& \pm 5
\end{aligned}
\] & \[
\begin{aligned}
& 12 \\
& \pm 1 / 2 \\
& \pm 0.9 \\
& \pm 5 \\
& \\
& \pm 5 \\
& \\
& \pm 6 \\
& \pm 5
\end{aligned}
\] & \[
\begin{aligned}
& 12 \\
& \pm 1 \\
& \pm 0.9 \\
& \pm 6 \\
& \\
& \pm 7 \\
& \\
& \pm 7 \\
& \pm 5
\end{aligned}
\] & \begin{tabular}{l}
Bits \\
LSB max \\
LSB max \\
LSB max \\
LSB max \\
LSB max \\
ppm of FSR \(/{ }^{\circ} \mathrm{C}\) typ
\end{tabular} & \begin{tabular}{l}
Guaranteed Monotonic
\[
\mathrm{V}_{\mathrm{Ss}}=0 \mathrm{~V} \text { or }-12 \mathrm{~V} \text { to }-15 \mathrm{~V}^{1} ; \mathrm{DAC}
\] \\
Latch Contents All 0s
\[
\mathrm{V}_{\mathrm{ss}}=-12 \mathrm{~V} \text { to }-15 \mathrm{~V}^{1}
\] \\
DAC Latch Contents All 0s
\end{tabular} \\
\hline \begin{tabular}{l}
REFERENCE OUTPUT \\
REFOUT \\
Reference Temperature Coefficient Reference Load Change ( \(\Delta \mathrm{V}_{\text {REFOUT }}\) vs. \(\mathrm{I}_{\mathrm{L}}\) )
\end{tabular} & \[
\begin{aligned}
& 4.95 / 5.05 \\
& \pm 25 \\
& -1
\end{aligned}
\] & \[
\begin{aligned}
& 4.95 / 5.05 \\
& \pm 25 \\
& -1
\end{aligned}
\] & \[
\left\{\begin{array}{l}
4.95 / 5.05 \\
\pm 30 \\
-1
\end{array}\right.
\] & \begin{tabular}{l}
\(\mathrm{V} \min / \mathrm{V} \max\) \(\mathrm{ppm} /{ }^{\circ} \mathrm{C}\) typ \\
mV max
\end{tabular} & \begin{tabular}{l}
Reference Load Current ( \(\mathrm{I}_{\mathrm{L}}\) ) \\
Change ( \(0 \mu \mathrm{~A}-100 \mu \mathrm{~A}\) )
\end{tabular} \\
\hline \begin{tabular}{l}
REFERENCE INPUT \\
Reference Input Range, REFIN Input Current
\end{tabular} & \[
\begin{aligned}
& 4.95 / 5.05 \\
& 5
\end{aligned}
\] & \[
\begin{aligned}
& 4.95 / 5.05 \\
& 5
\end{aligned}
\] & \[
\begin{array}{|l|}
4.95 / 5.05 \\
5
\end{array}
\] & \[
\begin{aligned}
& \mathrm{V} \min / V \max \\
& \mu \mathrm{~A} \max
\end{aligned}
\] & \(5 \mathrm{~V} \pm 1 \%\) \\
\hline \begin{tabular}{l}
DIGITAL INPUTS \\
Input High Voltage, \(\mathrm{V}_{\text {INH }}\) Input Low Voltage, \(\mathrm{V}_{\text {INL }}\) Input Current \(\mathrm{I}_{\mathrm{IN}}\) Input Capacitance \({ }^{5}\)
\end{tabular} & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 1 \\
& 8
\end{aligned}
\] & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 1 \\
& 8
\end{aligned}
\] & \[
\left\lvert\, \begin{gathered}
2.4 \\
0.8 \\
\pm 1 \\
8
\end{gathered}\right.
\] & \begin{tabular}{l}
V min \\
V max \\
\(\mu \mathrm{A}\) max pF max
\end{tabular} & \(\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}\) to \(\mathrm{V}_{\mathrm{DD}}\) \\
\hline \begin{tabular}{l}
ANALOG OUTPUTS \\
Output Range Resistor, \(\mathrm{R}_{\mathrm{OFSA}} \& \mathrm{R}_{\mathrm{OFSB}}\) Output Voltage Ranges \({ }^{6}\) Output Voltage Ranges \({ }^{6}\) DC Output Impedance
\end{tabular} & \[
\begin{aligned}
& 15 / 30 \\
& +5,+10 \\
& +5,+10, \pm 5 \\
& 0.5
\end{aligned}
\] & \[
\begin{aligned}
& 15 / 30 \\
& +5,+10 \\
& +5,+10, \pm 5 \\
& 0.5
\end{aligned}
\] & \[
\begin{aligned}
& 15 / 30 \\
& +5,+10 \\
& +5,+10, \pm 5 \\
& 0.5
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{k} \Omega \min / \max \\
& \mathrm{V} \\
& \mathrm{~V} \\
& \Omega \operatorname{typ}
\end{aligned}
\] & \begin{tabular}{l}
Single Supply; \(\mathrm{V}_{\text {SS }}=0 \mathrm{~V}\) \\
Dual Supply; \(\mathrm{V}_{\mathrm{SS}}=-12 \mathrm{~V}\) or -15 V
\end{tabular} \\
\hline \begin{tabular}{l}
AC CHARACTERISTICS \({ }^{5}\) \\
Voltage Output Settling-Time \\
Positive Full-Scale Change \\
Negative Full-Scale Change \\
Digital-to-Analog Glitch Impulse \({ }^{3}\) \\
Digital Feedthrough \({ }^{3}\) \\
Digital Crosstalk \({ }^{3}\)
\end{tabular} & \[
\begin{aligned}
& 10 \\
& 10 \\
& 10 \\
& 30 \\
& 10 \\
& 10
\end{aligned}
\] & \[
\begin{aligned}
& 10 \\
& 10 \\
& 10 \\
& 30 \\
& 10 \\
& 10 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 10 \\
& 10 \\
& 10 \\
& 30 \\
& 10 \\
& 10 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
\(\mu \mathrm{s} \max\) \\
\(\mu \mathrm{s}\) max \\
\(\mu s\) typ \\
nV secs typ \\
nV secs typ \\
nV secs typ
\end{tabular} & \begin{tabular}{l}
Settling Time to Within \\
\(\pm 1 / 2\) LSB of Final Value \\
Typically \(3 \mu \mathrm{~s}\) \\
Typically \(5 \mu \mathrm{~s} . \mathrm{V}_{\text {Ss }}=-12 \mathrm{~V}\) to -15 V
\[
\mathrm{V}_{\mathrm{ss}}=0 \mathrm{~V}
\] \\
DAC Latch Contents Toggled \\
Between All Os and All 1s
\end{tabular} \\
\hline POWER REQUIREMENTS
\[
\begin{aligned}
& \mathrm{V}_{\mathrm{DD}} \text { Range } \\
& \mathrm{V}_{\mathrm{Ss}} \text { Range (Dual Supplies) } \\
& \mathrm{I}_{\mathrm{DD}} \\
& \mathrm{I}_{\mathrm{SS}} \text { (Dual Supplies) }
\end{aligned}
\] & \[
\begin{aligned}
& +10.8 /+16.5 \\
& -10.8 /-16.5 \\
& 15 \\
& 5
\end{aligned}
\] & \[
\begin{aligned}
& +11.4 /+15.75 \\
& -11.4 /-15.75 \\
& 15 \\
& 5
\end{aligned}
\] & \[
\begin{aligned}
& +11.4 /+15.75 \\
& -11.4 /-15.75 \\
& 15 \\
& 5
\end{aligned}
\] & \begin{tabular}{l}
\(V \min / V \max\) \\
\(\mathrm{V} \min / \mathrm{V} \max\) \\
mA max \\
\(\mathrm{mA} \max\)
\end{tabular} & \begin{tabular}{l}
For Specified Performance Unless Otherwise Stated \\
For Specified Performance Unless Otherwise Stated Output Unloaded; Typically 11 mA Output Unloaded; Typically 3 mA
\end{tabular} \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Power supply tolerance, A Version: \(\pm 10 \%\); B, S Versions: \(\pm 5 \%\).
\({ }^{2}\) Temperature ranges are as follows: A, B Versions: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\); S Version: \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\).
\({ }^{3}\) See Terminology.
\({ }^{4}\) Measured with respect to REFIN and includes unipolar/bipolar offset error.
\({ }^{5}\) Guaranteed by design not production tested.
\({ }^{6} 0 \mathrm{~V}\) to 10 V output range available only with \(\mathrm{V}_{\mathrm{DD}} \geq 14.25 \mathrm{~V}\).
Specifications subject to change without notice.

TIMING CHARACTERISTICS \({ }^{1,2}\left(v_{D D}=+12 v\right.\) to \(+15 v^{3} V_{S S}=0 V\) or \(-12 V\) to \(-15 V^{3}{ }^{3}\) AGND \(=\) DGND \(=0 V, R_{L}=\)
\(2 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}\). All specifications \(\mathrm{T}_{\text {mIN }}\) to \(\mathrm{T}_{\text {mxx }}\) unless otherwise noted.)
\begin{tabular}{|c|c|c|c|c|}
\hline Parameter & Limit at \(+25^{\circ} \mathrm{C}\) (All Versions) & Limit at \(\mathbf{T}_{\text {MIN }}, \mathbf{T}_{\text {MAX }}\) (All Versions) & Units & Conditions/Comments \\
\hline \(\mathrm{t}_{1}{ }^{4}\) & 400 & 500 & ns min & SCLK Cycle Time \\
\hline \(\mathrm{t}_{2}\) & 50 & 50 & ns min & SYNC to SCLK Falling Edge Setup Time \\
\hline \(\mathrm{t}_{3}\) & 120 & 150 & ns min & SYNC to SCLK Hold Time \\
\hline \(\mathrm{t}_{4}\) & 10 & 10 & ns min & Data Setup Time \\
\hline \(\mathrm{t}_{5}\) & 170 & 225 & ns min & Data Hold Time \\
\hline \(\mathrm{t}_{6}\) & 0 & 0 & ns min & SYNC High to LDAC Low \\
\hline \(\mathrm{t}_{7}\) & 50 & 50 & ns min & LDAC Pulse Width \\
\hline \(\mathrm{t}_{8}\) & 0 & 0 & ns min & \(\overline{\text { LDAC }}\) High to SYNC Low \\
\hline \(\mathrm{t}_{9}\) & 75 & 75 & ns min & CLR Pulse Width \\
\hline \(\mathrm{t}_{10}\) & 75 & 100 & \(n \mathrm{nsm}\) & SYNC High Time \\
\hline
\end{tabular}

NOTES
\({ }^{1}\) Timing specifications guaranteed by design not production tested. All input signals are specified with \(\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%\) to \(90 \%\) of 5 V\()\) and timed from a voltage level of 1.6 V .
\({ }^{2}\) See Figure 8.
\({ }^{3}\) Power supply tolerance, A Version: \(\pm 10 \%\); B, S Versions: \(\pm 5 \%\).
\({ }^{4}\) SCLK Mark/Space Ratio range is \(45 / 55\) to \(55 / 45\).

\section*{ABSOLUTE MAXIMUM RATINGS \({ }^{1}\)}
\begin{tabular}{|c|c|}
\hline & \\
\hline \multicolumn{2}{|l|}{\(\mathrm{V}_{\mathrm{DD}}\) to AGND, DGND . . . . . . . . . . . . . -0.3 V to +1} \\
\hline \multicolumn{2}{|l|}{\(\mathrm{V}_{\text {ss }}\) to AGND, DGND . . . . . . . . . . . . +0.3 V to -17 V} \\
\hline \multicolumn{2}{|l|}{AGND to DGND} \\
\hline \multicolumn{2}{|l|}{\(\mathrm{V}_{\text {OUTA, }}{ }^{2}\) to AGND \(\ldots . . . . \mathrm{V}_{\text {Ss }}-0.3 \mathrm{~V}\) to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)} \\
\hline \multicolumn{2}{|l|}{REFOUT to AGND . . . . . . . . . . . . . . . . . . . . 0 V to V \({ }_{\text {DD }}\)} \\
\hline \multicolumn{2}{|l|}{REFIN to AGND . . . . . . . . . . -0.3 V to \(\mathrm{V}_{\text {DD }}+0.3 \mathrm{~V}\)} \\
\hline \multicolumn{2}{|l|}{Digital Inputs to DGND . . . . . . . -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)} \\
\hline \multicolumn{2}{|l|}{Operating Temperature Range} \\
\hline Industrial (A, B Versions) & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) \\
\hline \multicolumn{2}{|l|}{Extended (S Version) . . . . . . . . . . . . . \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)} \\
\hline \multicolumn{2}{|l|}{\multirow[t]{2}{*}{\begin{tabular}{l}
Junction Temperature . . . . . . . . . . . . . . . . . . . . . . \(+150^{\circ} \mathrm{C}\) \\
Storage Temperature Range . . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
\end{tabular}}} \\
\hline & \\
\hline \multicolumn{2}{|l|}{Power Dissipation Plastic DIP} \\
\hline \multicolumn{2}{|l|}{\(\theta_{\text {JA }}\) Thermal Impedance . . . . . . . . . . . . . . . \(+117^{\circ} \mathrm{C} / \mathrm{W}\)} \\
\hline Lead Temperature (Soldering, 10 sec & \(+300^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

Power Dissipation, Cerdip . . . . . . . . . . . . . . . . . 600 mW
\(\theta_{\text {JA }}\) Thermal Impedance . . . . . . . . . . . . . . . . . . . 76º\({ }^{\circ}\) //W
Lead Temperature (Soldering, 10 secs) . . . . . . . . \(+300^{\circ} \mathrm{C}\)
Power Dissipation, SOIC . . . . . . . . . . . . . . . . . . . 600 mW
\(\theta_{\mathrm{JA}}\) Thermal Impedance . . . . . . . . . . . . . . . . . . . \(75^{\circ} \mathrm{C} / \mathrm{W}\)
Lead Temperature (Soldering)
Vapor Phase ( 60 secs) . . . . . . . . . . . . . . . . . . . \(+215^{\circ} \mathrm{C}\)
Infrared ( 15 secs) . . . . . . . . . . . . . . . . . . . . . . \(+220^{\circ} \mathrm{C}\)

\section*{NOTES}
\({ }^{1}\) Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability Only one Absolute Maximum Rating may be applied at any time.
\({ }^{2}\) The outputs may be shorted to voltages in this range provided the power dissipation of the package is not exceeded.

\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD7249 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


\section*{PIN FUNCTION DESCRIPTION (DIP \& SOIC PIN NUMBERS)}
\begin{tabular}{|c|c|c|}
\hline Pin & Mnemonic & Description \\
\hline 1 & REFOUT & Voltage Reference Output. The internal 5 V analog reference is provided at this pin. To operate the part using its internal reference, REFOUT should be connected to REFIN. \\
\hline 2 & REFIN & Voltage Reference Input. It is internally buffered before being applied to both DACs. The nominal reference voltage for specified operation of the AD7249 is 5 V . \\
\hline 3 & \(\mathrm{R}_{\text {OFSB }}\) & Output Offset Resistor for the amplifier of DAC B. It is connected to \(\mathrm{V}_{\text {OutB }}\) for the +5 V range, to AGND for the +10 V range and to REFIN for the -5 V to +5 V range. \\
\hline 4 & \(V_{\text {OUTB }}\) & Analog Output Voltage of DAC B. This is the buffer amplifier output voltage. Three different output voltage ranges can be chosen: 0 to \(+5 \mathrm{~V}, 0\) to +10 V and -5 V to +5 V . \\
\hline 5 & AGND & Analog Ground. Ground reference for all analog circuitry. \\
\hline 6 & \(\overline{\text { CLR }}\) & Clear, Logic Input. Taking this input low clears both DACs. It sets \(\mathrm{V}_{\text {Outa }}\) and \(\mathrm{V}_{\text {Outb }}\) to 0 V in both unipolar ranges and the twos complement bipolar range and to -REFIN in the offset binary bipolar range. \\
\hline 7 & \(\overline{\text { BIN }} / \mathrm{COMP}\) & Logic Input. This input selects the data format to be either binary or twos complement. In both unipolar ranges natural binary format is selected by connecting this input to a Logic " 0 ". In the bipolar configuration offset binary format is selected with a logic " 0 " while a Logic " 1 " selects twos complement. \\
\hline 8 & DGND & Digital Ground. Ground reference for all digital circuitry. \\
\hline 9 & SDIN & Serial Data In, Logic Input. The 16-bit serial data word is applied to this input. \\
\hline 10 & \(\overline{\text { LDAC }}\) & Load DAC, Logic Input. Updates both DAC outputs. The DAC outputs are updated on the falling edge of this signal or alternatively if this line is permanently low, an automatic update mode is selected whereby both DACs are updated on the 16th falling SCLK pulse. \\
\hline 11 & SCLK & Serial Clock, Logic Input. Data is clocked into the input register on each falling SCLK edge. \\
\hline 12 & SYNC & Data Synchronization Pulse, Logic Input. Taking this input low initializes the internal logic in readiness for a new data word. \\
\hline 13 & \(\mathrm{V}_{\text {DD }}\) & Positive Power Supply. \\
\hline 14 & \(V_{\text {OUTA }}\) & Analog Output Voltage of DAC A. This is the buffer amplifier output voltage. Three different output voltage ranges can be chosen: 0 to \(+5 \mathrm{~V}, 0\) to +10 V and -5 V to +5 V . \\
\hline 15 & \(\mathrm{V}_{\text {ss }}\) & Negative Power Supply (used for the output amplifier only) may be connected to 0 V for single supply operation or -12 V to -15 V for dual supplies. \\
\hline 16 & \(\mathrm{R}_{\text {OFSA }}\) & Output Offset Resistor for the amplifier of DAC A. It is connected to \(\mathrm{V}_{\text {OUTA }}\) for the +5 V range, to AGND for the +10 V range and to REFIN for the -5 V to +5 V range. \\
\hline
\end{tabular}

PIN CONFIGURATIONS
(DIP and SOIC)


ORDERING GUIDE
\begin{tabular}{l|l|l|l}
\hline Model & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Relative \\
Accuracy
\end{tabular} & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD7249AN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\mathrm{N}-16\) \\
AD7249BN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\mathrm{N}-16\) \\
AD7249AR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\mathrm{R}-16\) \\
AD7249BR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\mathrm{R}-16\) \\
AD7249SQ \({ }^{2}\) & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\mathrm{Q}-16\) \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) For outline information see Package Information section.
\({ }^{2}\) Ávailabie to \(/ 883 \mathrm{~B}\) processing oniy. Contact your local saies office for military data sheet.

\section*{TERMINOLOGY}

\section*{Bipolar Zero Error}

Bipolar Zero Error is the voltage measured at \(\mathrm{V}_{\text {Out }}\) when the DAC is configured for bipolar output and loaded with all 0s (Twos Complement Coding) or with 100000000000 (Offset Binary Coding). It is due to a combination of offset errors in the DAC, amplifier and mismatch between the internal gain resistors around the amplifier.

\section*{Full-Scale Error}

Full-Scale Error is a measure of the output error when the amplifier output is at full scale (for the bipolar output range full scale is either positive or negative full scale). It is measured with respect to the reference input voltage and includes the offset errors.

\section*{Digital-to-Analog Glitch Impulse}

This is the voltage spike that appears at \(\mathrm{V}_{\text {Out }}\) when the digital code in the DAC Latch changes, before the output settles to its final value. The energy in the glitch is specified in nV secs, and is measured for an all codes change from 000000000000 to 111111111111.

\section*{Digital Feedthrough}

This is a measure of the voltage spike that appears on \(V_{\text {OUT }}\) as a result of feedthrough from the digital inputs on the AD7249. It is measured with \(\overline{\text { LDAC }}\) held high.

\section*{Relative Accuracy (Linearity)}

Relative Accuracy, or endpoint linearity, is a measure of the maximum deviation of the DAC transfer function from a straight line passing through the endpoints of the transfer function. It is measured after allowing for zero and full-scale errors and is expressed in LSBs or as a percentage of full-scale reading.

\section*{Single Supply Linearity and Gain Error}

The output amplifier on the AD7249 can have true negative offsets even when the part is operated from a single +15 V supply. However, because the negative supply rail \(\left(\mathrm{V}_{\mathrm{ss}}\right)\) is 0 V , the output cannot actually go negative. Instead, when the output offset voltage is negative, the output voltage sits at 0 V , resulting in the transfer function shown in Figure 1.


Figure 1. Effect of Negative Offset (Single Supply)

This "knee" is an offset effect, not a linearity error, and the transfer function would have followed the dotted line if the output voltage could have gone negative.
Normally, linearity is measured between zero (all 0 s input code) and full scale (all 1s input code) after offset and full scale have been adjusted out or allowed for, but this is not possible in single supply operation if the offset is negative, due to the knee in the transfer function. Instead, linearity of the AD7249 in the unipolar mode is measured between full scale and the lowest code which is guaranteed to produce a positive output voltage. This code is calculated from the maximum specification for negative offset. For the A and B versions, the linearity is measured between Codes 3 and 4095. For the \(S\) grade, linearity is measured between Code 5 and Code 4095.

\section*{Differential Nonlinearity}

Differential Nonlinearity is the difference between the measured change and the ideal 1 LSB change between any two adjacent codes. A specified differential nonlinearity of \(\pm 1\) LSB or less over the operating temperature range ensures monotonicity.

\section*{Unipolar Offset Error}

Unipolar Offset Error is the measured output voltage from \(\mathrm{V}_{\text {Out }}\) with all zeros loaded into the DAC latch, when the DAC is configured for unipolar output. It is due to a combination of the offset errors in the DAC and output amplifier.

\section*{CIRCUIT INFORMATION}

D/A Section
The AD7249 contains two 12 -bit voltage-mode D/A converters consisting of highly stable thin film resistors and high-speed NMOS single-pole, double-throw switches. The simplified circuit diagram for the DAC section is shown in Figure 2. The output voltage from the converter has the same polarity as the reference voltage, REFIN, allowing single supply operation.


Figure 2. D/A Simplified Circuit Diagram

\section*{Internal Reference}

The AD7249 has an on-chip temperature compensated buried Zener reference which is factory trimmed to \(5 \mathrm{~V} \pm 50 \mathrm{mV}\). The reference voltage is provided at the REFOUT pin. This reference can be used to provide the reference voltage for the D/A converter by connecting the REFOUT pin to the REFIN pin.
The reference voltage can also be used as à reference for other components and is capable of providing up to \(500 \mu \mathrm{~A}\) to an external load. The maximum recommended capacitance on REFOUT for normal operation is 50 pF . If the reference output is required to drive a capacitive load greater than 50 pF , then a \(200 \Omega\) resistor should be placed in series with the capacitive load. Figure 3 shows the suggested REF OUT decoupling scheme, a \(200 \Omega\) resistor and the parallel combination of a \(10 \mu \mathrm{~F}\) tantalum and a \(0.1 \mu \mathrm{~F}\) ceramic capacitor. This decoupling scheme reduces the noise spectral density of the reference.


Figure 3. Reference Decoupling Scheme

\section*{External Reference}

In some applications, the user may require a system reference or some other external reference to drive the AD7249. References such as the AD586 provide an ideal external reference source (See Figure 10). The REFIN voltage is internally buffered by a unity gain amplifier before being applied to the D/A converter. The D/A converter is scaled for a 5 V reference and the device is tested with 5 V applied to REFIN. Other reference voltages may be used with degraded performance. Figure 4 shows the degradation in linearity vs. REFIN.


Figure 4. Linearity vs. REFIN Voltage

\section*{Op Amp Section}

The output of the voltage-mode D/A converter is buffered by a noninverting CMOS amplifier. The \(\mathbf{R}_{\text {OFS }}\) input allows three output voltage ranges to be selected. The buffer amplifier is capable of developing +10 V across a \(2 \mathrm{k} \Omega\) load to AGND.
The output amplifier can be operated from a single +15 V supply by tying \(\mathrm{V}_{\mathrm{ss}}=0 \mathrm{~V}\).
The amplifier can also be operated from dual supplies to allow an additional bipolar output range of -5 V to +5 V . Dual supplies are necessary for the bipolar output range but can also be used for the unipolar ranges to give faster settling time to voltages near 0 V , to allow full sink capability of 2.5 mA over the entire output range and to eliminate the effects of negative offsets on the transfer characteristic (outlined previously). A plot of the output sink capability of the amplifier is shown in Figure 5.


Figure 5. Amplifier Sink Current


Figure 6. Noise Spectral Density vs. Frequency

\section*{DIGITAL INTERFACE}

The AD7249 contains an input serial to parallel shift register and a DAC latch for both DAC A and DAC B. A simplified diagram of the input loading circuitry is shown in Figure 7. Serial data on the SDIN input is loaded to the input register under control of SYNC and SCLK. The SYNC input provides the frame synchronization signal which tells the AD7249 that valid serial data on the SDIN input will be available for the next 16 falling edges of SCLK. An internal counter/decoder circuit provides a low gating signal so that only 16 data bits are clocked into the input shift register. After 16 SCLK pulses the internal gating signal goes inactive (high) thus locking out any further clock pulses. Therefore either a continuous clock or a burst clock source may be used to clock in the data. The SYNC input is taken high after the complete 16 -bit word is loaded in.
DAC selection is accomplished using the thirteenth bit (DB12) of the serial data input stream. A zero in DB12 will select DAC A while a one in this position selects DAC B. Although 16 bits of data are clocked into the input register, only 12 bits get transferred into the DAC latch. The relevant DAC latch is determined by the value of the thirteenth bit and the first three bits in the 16 -bit stream are don't cares. Therefore, the data format is three don't cares followed by the DAC selection bit and the 12-bit data word with the LSB as the last bit in the serial stream.

There are two ways in which a DAC latches and hence the analog outputs may be updated. The status of the \(\overline{\text { LDAC }}\) input is examined after \(\overline{\text { SYNC }}\) is taken low. Depending on its status, one of two update modes are selected.
If \(\overline{\text { LDAC }}=0\), then the automatic update mode is selected. In this mode the DAC latch and analog output are updated automatically when the last bit in the serial data stream is clocked in. The update thus takes place on the sixteenth falling SCLK edge.
If \(\overline{\text { LDAC }}=1\), then the automatic update is disabled and both DAC latches are updated by taking \(\overline{\text { LDAC }}\) low any time after the 16 -bit data transfer is complete. The update now occurs on the falling edge of \(\overline{\mathrm{LDAC}}\). Note that the \(\overline{\mathrm{LDAC}}\) input must be taken back high again before the next data transfer is initiated. When a complete word is held in the shift register it may then be loaded into the DAC latch under control of LDAC.

\section*{Clear Function ( \(\overline{\mathbf{C L R}}\) )}

The clear function clears the contents of the input shift register and loads both DAC Latches with all 0s. It is activated by taking \(\overline{\mathrm{CLR}}\) low. In all ranges except the Offset Binary bipolar range ( -5 V to +5 V ) the output voltage is reset to 0 V . In the offset binary bipolar range the output is set to -REFIN. The clear function is especially useful at power-up as it enables the output to be reset to a known state.


Figure 7. Simplified Loading Structure


Figure 8. Timing Diagram

\section*{TRANSFER FUNCTION}

The internal scaling resistors provided on the AD7249 allow several output voltage ranges. The part can produce unipolar output ranges of 0 V to +5 V or 0 V to +10 V and a bipolar output range of \(\pm 5 \mathrm{~V}\). Connections for the various ranges are outlined below. Since each DAC has its own \(\mathrm{R}_{\text {OFS }}\) input the two DACs can be set up for different output ranges.

\section*{Unipolar ( \(\mathbf{0} \mathbf{V}\) to +10 V ) Configuration}

The first of the configurations provides an output voltage range of 0 V to +10 V . This is achieved by connecting the output offset resistor \(\mathrm{R}_{\mathrm{OFSA}}, \mathrm{R}_{\mathrm{OFSB}}(\operatorname{Pin} 3,16)\) to AGND. Natural Binary data format is selected by connecting BIN / COMP (Pin 7) to DGND. In this configuration, the AD7249 can be operated using either single or dual supplies. Note that the \(V_{D D}\) supply is


Figure 9. Unipolar ( 0 V to +10 V ) Configuration
restricted to \(+15 \mathrm{~V} \pm 10 \%\) for this range in order to maintain sufficient amplifier headroom. Dual supplies may be used to improve settling time and give increased current sink capability for the amplifier. Figure 9 shows the connection diagram for unipolar operation of the AD7249. Table I shows the digital code vs. analog output for this configuration.
Unipolar ( 0 V to +5 V ) Configuration
The 0 V to +5 V output voltage range is achieved by tying \(\mathrm{R}_{\text {OFSA }}\) to \(\mathrm{V}_{\text {OUTA }}\) or \(\mathrm{R}_{\text {OFSB }}\) to \(\mathrm{V}_{\text {OUTB }}\). Once again, the AD7249 can be operated using either single or dual supplies. The table for output voltage versus digital code is as in Table I, with 2REFIN replaced by REFIN. Note, for this range, 1 LSB = REFIN \(\cdot\left(2^{-12}\right)=(\) REFIN/4096).

Table I. Unipolar Code Table ( 0 V to +10 V Range)
\begin{tabular}{|c|c|c|c|}
\hline Input & Data Word MSB & LSB & Analog Output, \(\mathbf{V}_{\text {OUt }}\) \\
\hline XXXY & 11111111 & 1111 & +2REFIN - (4095/4096) \\
\hline XXXY & 10000000 & 0001 & +2REFIN - \({ }^{\text {2049/4096) }}\) \\
\hline XXXY & 10000000 & 0000 & +2REFIN \(\cdot(2048 / 4096)=+\) REFIN \\
\hline XXXY & 01111111 & 1111 & +2REFIN - \(2047 / 4096\) ) \\
\hline XXXY & 00000000 & 0001 & +2REFIN - \((1 / 4096)\) \\
\hline XXXY & 00000000 & 0000 & 0 V \\
\hline
\end{tabular}

X = Don't Care.
\(\mathrm{Y}=\mathrm{DAC}\) Select Bit, \(0=\mathrm{DACA}, 1=\mathrm{DACB}\).
Note: 1 LSB \(=2\) REFIN/4096.

\section*{Bipolar ( \(\mathbf{~} 5 \mathrm{~V}\) ) Configuration}

The bipolar configuration for the AD7249, which gives an output range of -5 V to +5 V , is achieved by connecting \(\mathrm{R}_{\mathrm{OFSA}}\), \(\mathrm{R}_{\mathrm{OFSB}}\) to \(\mathrm{V}_{\text {REFIN }}\). The AD7249 must be operated from dual supplies to achieve this output voltage range. Either offset binary or twos complement coding may be selected. Figure 10 shows the connection diagram for bipolar operation. An AD586 provides the reference voltage for the DAC but this could be provided by the on-chip reference by connecting REFOUT to REFIN.


Figure 10. Bipolar Configuration with External Reference
Bipolar Operation (Twos Complement Data Format)
The AD7249 is configured for twos complement data format by connecting \(\overline{\text { BIN }} / \mathrm{COMP}\) (Pin 7) high. The analog output vs. digital code is shown in Table II.

Table II. Twos Complement Bipolar Code Table
\begin{tabular}{|c|c|c|c|}
\hline Input & Data Word MSB & LSB & Analog Output, \(\mathbf{V}_{\text {Out }}\) \\
\hline XXXY & 01111111 & 1111 & +REFIN • (2047/2048) \\
\hline XXXY & 00000000 & 0001 & + REFIN - (1/2048) \\
\hline XXXY & 00000000 & 0000 & 0 V \\
\hline XXXY & 11111111 & 1111 & -REFIN - (1/2048) \\
\hline XXXY & 10000000 & 0001 & -REFIN • (2047/2048) \\
\hline XXXY & 10000000 & 0000 & -REFIN \(\cdot(2048 / 2048)=-\) REFIN \\
\hline
\end{tabular}

\section*{\(\mathbf{X}=\) Don't Care.}
\(\mathbf{Y}=\) DAC Select Bit, \(0=\) DACA, \(1=\) DACB.
Note: 1 LSB = REFIN/2048.

\section*{Bipolar Operation (Offset Binary Data Format)}

The AD7249 is configured for Offset Binary data format by connecting \(\overline{\mathrm{BIN}} / \mathrm{COMP}\) (Pin 7) low. The analog output vs. digital code may be obtained by inverting the MSB in Table II.

\section*{APPLYING THE AD7249}

Good printed circuit board layout is as important as the overall circuit design itself in achieving high speed converter performance. The AD7249 works on an LSB size of 2.44 mV for the unipolar 0 V to 10 V range and the bipolar \(\pm 5 \mathrm{~V}\) range, when using the unipolar 0 V to 5 V range the LSB size is 1.22 mV . Therefore the designer must be conscious of minimizing noise in both the converter itself and in the surrounding circuitry. Switching mode power supplies are not recommended as switching spikes can feedthrough to the on-chip amplifier. Other causes of concern are ground loops and feedthrough from microprocessors. These are factors which influence any high performance converter, and proper printed circuit board layout which minimizes these effects is essential to obtain high performance.

\section*{LAYOUT HINTS}

Ensure that the layout has the digital and analog tracks separated as much as possible. Take care not to run any digital track alongside an analog signal track. Establish a single point analog ground separate from the logic system ground. Place this star ground as close as possible to the AD7249. Connect all analog grounds to this star point and also connect the AD7249 DGND pin to this point. Do not connect any other digital grounds to this analog ground point. Low impedance analog and digital power supply common returns are essential for low noise operation of high performance converters. To accomplish this track widths should be kept a wide as possible and also the use of ground planes minimizes impedance paths and also guards the analog circuitry from digital noise.

\section*{NOISE}

Keep the signal leads on the \(\mathrm{V}_{\text {Outa }}\) and \(\mathrm{V}_{\text {Outb }}\) signals and the signal return leads to AGND as short as possible to minimize noise coupling. In applications where this is not possible use a shielded cable between the DAC outputs and their destination. Reduce the ground circuit impedance as much as possible since any potential difference in grounds between the DAC and its destination device appears as an error voltage in series with the DAC output.

\section*{Power Supply Decoupling}

To achieve optimum performance when using the AD7249, the \(\mathrm{V}_{\mathrm{DD}}\) and \(\mathrm{V}_{\text {SS }}\) lines should be decoupled to AGND using \(0.1 \mu \mathrm{~F}\) capacitors. In noisy environments it is recommended that \(10 \mu \mathrm{~F}\) capacitors be connected in parallel with the \(0.1 \mu \mathrm{~F}\) capacitors.

\section*{MICROPROCESSOR INTERFACING}

Microprocessor interfacing to the AD7249 is via a serial bus which uses standard protocol compatible with DSP processors and microcontrollers. The communications channel requires a three-wire interface consisting of a clock signal, a data signal and a synchronization signal. The AD7249 requires a 16 -bit data word with data valid on the falling edge of SCLK. For all the interfaces, the DAC update may be done automatically when all the data is clocked in or it may be done under control of LDAC.
Figures 11 to 15 show the AD7249 configured for interfacing to a number of popular DSP processors and microcontrollers.

\section*{AD7249-ADSP-2101/ADSP-2102 Interface}

Figure 11 shows a serial interface between the AD7249 and the ADSP-2101/ ADSP-2102 DSP processor. The ADSP-2101/ ADSP-2102 contains two serial ports and either port may be used in the interface. The data transfer is initiated by TFS going low. Data from the ADSP-2101/ADSP-2102 is clocked into the AD7249 on the falling edge of SCLK. DB12 of the 16-bit serial data stream selects the DAC to be updated. Both DACs can be updated by holding \(\overline{\text { LDAC }}\) high while performing two write cycles to the DAC. TFS must be taken high after each 16 bit write cycle. \(\overline{\text { LDAC }}\) is brought low at the end of the second cycle and both DAC outputs are updated together. In the interface shown the DAC is updated using an external timer

*ADDITIONAL PINS OMITTED FOR CLARITY.
Figure 11. AD7249-ADSP-2101/ADSP-2102 Interface
which generates an \(\overline{\text { LDAC }}\) pulse. This could also be done using a control or decoded address line from the processor. Alternatively, if the \(\overline{\text { LDAC }}\) input is hardwired low the output update takes place automatically on the 16th falling edge of SCLK.

\section*{AD7249-DSP56000 Interface}

A serial interface between the AD7249 and the DSP56000 is shown in Figure 12. The DSP56000 is configured for Normal Mode Asynchronous operation with Gated Clock. It is also set up for a 16-bit word with SCK and SC2 as outputs and the FSL control bit set to a " 0 ." SCK is internally generated on the DSP56000 and applied to the AD7249 SCLK input. Data from
the DSP56000 is valid on the falling edge of SCK. The SC2 output provides the framing pulse for valid data. This line must be inverted before being applied to the SYNC input of the AD7249.


Figure 12. AD7249-DSP5600 Interface
In this interface an external \(\overline{\text { LDAC }}\) pulse generated from an external timer is used to update the outputs of the DACs. This update can also be produced using a bit programmable control line from the DSP56000.

\section*{AD7249-TMS32020 Interface}

Figure 13 shows a serial interface between the AD7249 and the TMS32020 DSP processor. In this interface, the CLKX and FSX signals for the TMS32020 should be generated using external clock/timer circuitry. The FSX pin of the TMS 32020 must be configured as an input. Data from the TMS32020 is valid on the falling edge of CLKX.
The clock/timer circuitry generates the \(\overline{\text { LDAC }}\) signal for the AD7249 to synchronize the update of the output with the serial transmission. Alternatively, the automatic update mode may be selected by connecting \(\overline{\mathrm{LDAC}}\) to DGND.

*ADDITIONAL PINS OMITTED FOR CLARITY.
Figure 13. AD7249-TMS32020 Interface

\section*{AD7249-68HC11 Interface}

Figure 14 shows a serial interface between the AD7249 and the 68 HCll microcontroller. SCK of the 68 HCll drives SCLK of the AD7249 while the MOSI output drives the serial data line of the AD7249. The \(\overline{\text { SYNC signal is derived from a port line (PC0 }}\) shown).
For correct operation of this interface, the 68 HCl 1 should be configured such that its CPOL bit is a 0 and its CPHA bit is a 1. When data is to be transmitted to the part, PC0 is taken low. When the \(68 \mathrm{HCl1}\) is configured like this, data on MOSI is valid on the falling edge of SCK. The 68 HCl 1 transmits its serial data in 8 -bit bytes with only eight falling clock edges occurring in the transmit cycle. To load data to the AD7249, PC0 is left low after the first eight bits are transferred and a second byte of data is then transferred serially to the AD7249. When the second serial transfer is complete, the PC0 line is taken high.
Figure 14 shows the \(\overline{\text { LDAC }}\) input of the AD7249 being driven from another bit programmable port line (PC1). As a result, both DACs can be updated simultaneously by taking LDAC low after both DACs latches have updated.

*ADDITIONAL PINS OMITTED FOR CLARITY.
Figure 14. AD7249-68HC11 Interface

\section*{AD7249-87C51 Interface}

A serial interface between the AD7249 and the 87C51 microcontroller is shown in Figure 15. TXD of the 87C51 drives SCLK of the AD7249 while RXD drives the serial data line of the part. The SYNC signal is derived from the port line P3.3 and the \(\overline{\text { LDAC }}\) line is driven port line P3.2.
The 87C51 provides the LSB of its SBUF register as the first bit in the serial data stream. Therefore, the user will have to ensure that the data in the SBUF register is arranged correctly so that the don't care bits are the first to be transmitted to the AD7249 and the last bit to be sent is the LSB of the word to be loaded to the AD7249. When data is to be transmitted to the part, P3.3 is taken low. Data on RXD is valid on the falling edge of TXD. The 87C51 transmits its serial data in 8-bit bytes with only eight falling clock edges occurring in the transmit cycle. To load data
to the AD7249, P3.3 is left low after the first eight bits are transferred, and a second byte of data is then transferred serially to the AD7249 with DB12 used to select the appropriate DAC register. When the second serial transfer is complete, the P3.3 line is taken high and then taken low again to start the loading sequence to the second DAC (see timing diagram Figure 8).
Figure 15 shows the \(\overline{\text { LDAC }}\) input of the AD7249 driven from the bit programmable port line P3.2. As a result, both DAC outputs can be updated simultaneously by taking the \(\overline{\text { LDAC }}\) line low following the completion of the write cycle to the second DAC. Alternatively \(\overline{\mathrm{LDAC}}\) could be hardwired low and the analog output will be updated on the sixteenth falling edge of TXD after the \(\overline{\mathrm{SYNC}}\) signal for the DAC has gone low.


Figure 15. AD7249-87C51 Interface

\section*{APPLICATIONS}

\section*{OPTO-ISOLATED INTERFACE}

In many process control type applications it is necessary to provide an isolation barrier between the controller and the unit being controlled. Opto-isolators can provide voltage isolation in excess of \(3 \mathrm{k} \Omega\). The serial loading structure of the AD7249 makes it ideal for opto-isolated interfaces as the number of interface lines is kept to a minimum.

Figure 16 shows a 2-channel isolated interface using the AD7249.
The sequence of events to program the output channels is as follows.
1. Take the \(\overline{\text { SYNC }}\) line low.
2. Transmit the 16 -bit word for DAC A (DB 12 of the 16 bit data word selects the DAC, DB12 \(=0\) to select DAC A ) and bring the SYNC line high after the 16 bits have been transmitted.
3. Bring \(\overline{\text { SYNC }}\) line low again and transmit 16 bits for DAC B, bring SYNC back high at end of transmission.
4. Pulse the \(\overline{\mathrm{LDAC}}\) line low. This updates both output channels simultaneously on the falling edge of LDAC.


Figure 16. Opto-Isolated Interface

\section*{FEATURES}

Microprocessor Compatible (6800, 8085, Z80, etc.)
TTL/CMOS Compatible Inputs
On-Chip Data Latches
End Point Linearity
Low Power Consumption
Monotonicity Guaranteed (Full Temperature Range)
Latch Free (No Protection Schottky Required)

\section*{APPLICATIONS}

Microprocessor Controlled Gain Circuits
Microprocessor Controlled Attenuator Circuits Microprocessor Controlled Function Generation Precision AGC Circuits
Bus Structured Instruments

FUNCTIONAL BLOCK DIAGRAM


\section*{GENERAL DESCRIPTION}

The AD7524 is a low cost, 8 -bit monolithic CMOS DAC designed for direct interface to most microprocessors.

Basically an 8-bit DAC with input latches, the AD7524's load cycle is similar to the "write" cycle of a random access memory. Using an advanced thin-film on CMOS fabrication process, the AD7524 provides accuracy to \(1 / 8 \mathrm{LSB}\) with a typical power dissipation of less than 10 milliwatts.
A newly improved design eliminates the protection Schottky previously required and guarantees TTL compatibility when using a +5 V supply. Loading speed has been increased for compatibility with most microprocessors.
Featuring operation from +5 V to +15 V , the AD75 24 interfaces directly to most microprocessor buses or output ports.
Excellent multiplying characteristics (2- or 4-quadrant) make the AD7524 an ideal choice for many microprocessor controlled gain setting and signal control applications.

\footnotetext{
This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.
}

\section*{AD7524-SPEG|FICATIONS \({ }_{\left(v_{\text {REF }}\right.}=+10 v, v_{\text {OUT1 }}=v_{\text {OUT } 2}=0 v\), unless otherwise noted \()\)}
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline PARAMETER & \multicolumn{2}{|l|}{LIMIT, \(\mathrm{TA}_{\text {A }}=+25^{\circ} \mathrm{C}\)} & \multicolumn{2}{|l|}{LIMIT, \(\mathrm{T}_{\text {MIN }}, \mathrm{T}_{\text {MAX }}{ }^{1}\)} & UNITS & TEST CONDITIONS/COMMENTS \\
\hline \multicolumn{7}{|l|}{STATIC PERFORMANCE} \\
\hline Resolution & & 8 & 8 & 8 & Bits & \\
\hline \multicolumn{7}{|l|}{Relative Accuracy} \\
\hline J, A, S Versions: & \(\pm 1 / 2\) & \(\pm 1 / 2\) & \(\pm 1 / 2\) & \(\pm 1 / 2\) & LSB max & \\
\hline K, B, T Versions & \(\pm 1 / 2\). & \(\pm 1 / 4\). & \(\pm 1 / 2\) & \(\pm 1 / 4\) & LSB \(\max ^{\text {a }}\) & \(\cdots\) - . . \\
\hline L, C, U Versions & \(\pm 1 / 2\) & \(\pm 1 / 8\) & \(\pm 1 / 2\) & \(\pm 1 / 8\) & LSB max & \\
\hline Monotonicity & guaranteed & guaranteed & guaranteed & guaranteed & & \\
\hline Gain Error \({ }^{2}\) & \(\pm 21 / 2\) & \(\pm 11 / 4\) & \(\pm 31 / 2\) & \(\pm 11 / 2\) & LSB max & \\
\hline Average Gain TC \({ }^{3}\) & \(\pm 40\) & \(\pm 10\) & \(\pm 40\) & \(\pm 10\) & \(\mathrm{ppm} /{ }^{\circ} \mathrm{C}\) & Gain TC measured from \(+25^{\circ} \mathrm{C}\) to \\
\hline \multirow[t]{2}{*}{dc Supply Rejection, \({ }^{3} \Delta \mathrm{Gain} / \Delta \mathrm{V}_{\mathrm{DD}}\)} & 0.08 & 0.02 & 0.16 & 0.04 & \% FSR/\% max & \(\mathrm{T}_{\text {min }}\) or from \(+25^{\circ} \mathrm{C}\) to \(\mathrm{T}_{\text {max }}\)
\[
\Delta V_{D D}= \pm 10 \%
\] \\
\hline & 0.002 & 0.001 & 0.01 & 0.005 & \% FSR/\% typ & \\
\hline \multicolumn{7}{|l|}{Output Leakage Current} \\
\hline IOUT1 (Pin 1) & \(\pm 50\) & \(\pm 50\) & \(\pm 400\) & \(\pm 200\) & \(n A\) max & DB0-DB7 \(=0 \mathrm{~V} ; \overline{\mathrm{WR}}, \overline{\mathrm{CS}}=0 \mathrm{~V} ; \mathrm{V}_{\text {REF }}= \pm 10 \mathrm{~V}\) \\
\hline Iout2 (Pin 2) & \(\pm 50\) & \(\pm 50\) & \(\pm 400\) & \(\pm 200\) & \(n\) A max & DB0-DB7 \(=\mathrm{V}_{\text {DD }} ; \overline{\mathrm{WR}}, \overline{\mathrm{CS}}=0 \mathrm{~V} ; \mathrm{V}_{\text {REF }}= \pm 10 \mathrm{~V}\) \\
\hline \multicolumn{7}{|l|}{DYNAMIC PERFORMANCE} \\
\hline \begin{tabular}{l}
Output Current Settling Time \({ }^{3}\) \\
(to \(\mathbf{1 / 2} \mathbf{L S B}\) )
\end{tabular} & 400 & 250 & 500 & 350 & ns max & OUT1 Load \(=100 \Omega, \mathrm{C}_{\mathrm{EXT}}=13 \mathrm{pF} ; \overline{\mathrm{WR}}, \overline{\mathrm{CS}}=\) \(\mathbf{0 V} ;\) DB0-DB7 \(=\mathbf{O V}\) to \(\mathrm{V}_{\mathrm{DD}}\) to \(\mathbf{0 V}\). \\
\hline \multicolumn{7}{|l|}{ac Feedthrough \({ }^{3}\)} \\
\hline at OUT1 & 0.25 & 0.25 & 0.5 & 0.5 & \% FSR max & \(\mathrm{V}_{\text {REE }}= \pm \mathbf{1 0} \mathrm{V}, 100 \mathrm{kHz}\) sine wave; DB0-DB7 \(=\) \\
\hline at OUT2 & 0.25 & 0.25 & 0.5 & 0.5 & \% FSR \({ }_{\text {max }}\) & \(\mathrm{OV} ; \mathrm{WR}, \mathrm{CS}=0 \mathrm{~V}\) \\
\hline \multicolumn{7}{|l|}{REFERENCE INPUT} \\
\hline \(\mathbf{R}_{\text {IN }}\left(\mathbf{p i n} 15\right.\) to GND) \({ }^{4}\) & 5 & 5 & 5 & 5 & \(k \Omega\) min & \\
\hline & 20 & 20 & 20 & 20 & \(\mathrm{k} \Omega\) max & \\
\hline \multicolumn{7}{|l|}{ANALOG OUTPUTS
Output Capacitance} \\
\hline COut1 (pin 1) & 120 & 120 & 120 & 120 & pF max & DB0-DB7 \(=\mathrm{V}_{\text {DD }} ; \overline{\mathrm{WR}}, \overline{\mathrm{CS}}=0 \mathrm{~V}\) \\
\hline \(\mathrm{Cout2}^{\text {(pin 2) }}\) & 30 & 30 & 30 & 30 & \(\mathrm{pF}^{\text {max }}\) &  \\
\hline \(\mathrm{Cout1}^{\text {(pin 1) }}\) & 30 & 30 & 30 & 30 & pF max & DB0-DB7 \(=0 \mathrm{~V} ; \overline{\mathrm{WR}}, \overline{\mathrm{CS}}=0 \mathrm{~V}\) \\
\hline \(\mathrm{C}_{\text {Out2 }}(\mathrm{pin} 2)\) & 120 & 120 & 120 & 120 & pF max & \\
\hline \multicolumn{7}{|l|}{DIGITAL INPUTS} \\
\hline \multicolumn{7}{|l|}{Input HIGH Voltage Requirement} \\
\hline \multicolumn{7}{|l|}{Input LOW Voltage Requirement} \\
\hline \(\mathrm{V}_{\text {IL }}\) & +0.8 & +1.5 & +0.8 & +1.5 & \(\mathrm{V}_{\text {max }}\) & \\
\hline Input Current & & & & & , \% & \\
\hline \(\mathrm{I}_{\text {IN }}\) & \(\pm 1\) & \(\pm 1\) & \(\pm 10\) & \(\pm 10\) & \(\mu \mathrm{A}\) max & \(\mathbf{V}_{\mathbf{I N}}=\mathbf{O V}\) or \(\mathrm{V}_{\mathrm{DD}}\) \\
\hline \multicolumn{7}{|l|}{Input Capacitance \({ }^{3}\)} \\
\hline DB0-DB7 & 5 & 5 & 5 & 5 & pF max & \(\mathrm{V}_{\text {IN }}=0 \mathrm{~V}\) \\
\hline \(\overline{\text { Wr }}, \overline{\text { CS }}\) & 20 & 20 & 20 & 20 & pF max & \(\mathrm{V}_{\mathbf{I N}}=0 \mathrm{~V}\) \\
\hline \multicolumn{7}{|l|}{SWITCHING CHARACTERISTICS} \\
\hline \[
\mathrm{t}_{\mathrm{Cs}}
\] & & & & & & \(\mathbf{t}_{\mathbf{W R}}=\mathrm{t}_{\mathbf{C S}}\) \\
\hline AD7524J, K, L, A, B, C & 170 & 100 & 220 & 130 & ns min & \\
\hline AD7524S, T, U & 170 & 100 & 240 & 150 & ns min & \\
\hline \multicolumn{7}{|l|}{Chip Select to Write Hold Time} \\
\hline \[
\begin{aligned}
& \mathrm{t}_{\mathrm{CH}} \\
& \text { All Grades }
\end{aligned}
\] & 0 & 0 & 0 & 0 & ns min & \\
\hline \multicolumn{7}{|l|}{Write Pulse Width} \\
\hline \(t_{\text {WR }}\) & & & & & & \(\mathrm{t}_{\mathbf{C S}} \geqslant \mathrm{t}_{\text {WR }}, \mathrm{t}_{\mathbf{C H}} \geqslant 0\) \\
\hline AD7524J, K, L, A, B, C & 170 & 100 & 220 & 130 & ns min & \\
\hline AD7524S, T, U & 170 & 100 & 240 & 150 & ns min & \\
\hline \multicolumn{7}{|l|}{Data Setup Time} \\
\hline \multicolumn{7}{|l|}{\(t_{\text {dS }}\)} \\
\hline AD7524J, K, L, A, B, C & 135 & 60 & 170 & 80 & ns min & \(\cdots\) \\
\hline AD7524S, T, U & 135 & 60 & 170 & 100 & ns min & \\
\hline \multicolumn{7}{|l|}{Data Hold Time} \\
\hline \begin{tabular}{l}
\({ }^{\text {t }}\) D \\
All Grades
\end{tabular} & 10 & 10 & 10 & 10 & ns min & \\
\hline \multicolumn{7}{|l|}{POWER SUPPLY} \\
\hline \multirow[t]{2}{*}{IDD} & \[
\begin{aligned}
& 1 \\
& 100
\end{aligned}
\] & \[
\begin{aligned}
& 2 \\
& 100
\end{aligned}
\] & \[
\begin{aligned}
& 2 \\
& 500
\end{aligned}
\] & \[
\begin{aligned}
& 2 \\
& 500
\end{aligned}
\] & \(m A \max\) \(\mu \mathrm{A}\) max & All Digital Inputs \(\mathbf{V}_{\text {IL }}\) or \(\mathbf{V}_{\text {IH }}\) All Digital Inputs 0 V or \(\mathrm{V}_{\mathrm{DD}}\) \\
\hline & \[
100
\] & \[
100
\] & \[
500
\] & \[
500
\] & \[
\mu \mathrm{A} \max
\] & All Digital Inputs \(\mathbf{0 V}\) or \(V_{D D}\) \\
\hline
\end{tabular}

NOTES
\({ }^{1}\) Temperate ranges as follows: \(\mathrm{J}, \mathrm{K}, \mathrm{L}\) versions: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
A, B, C versions: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
\({ }^{2}\) Gain error is measured using internal feedback resistor. Full Scale Range (FRS) \(=\mathrm{V}_{\text {pary }}\).
\({ }^{3}\) Guaranteed, not tested.
\({ }^{4} \mathrm{DAC}\) thin-film resistor temperature coefficient is approximately \(-300 \mathrm{ppm} /{ }^{\circ} \mathrm{C}\).
\({ }^{5} \mathrm{AC}\) parameter, sample tested © \(25^{\circ} \mathrm{C}\) to ensure conformance to specifications.
Specifications subject to change without notice.

\section*{ABSOLUTE MAXIMUM RATINGS*}
( \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\), unless otherwise noted)
\(V_{\text {DD }}\) to GND . . . . . . . . . . . . . . . . . . \(-0.3 \mathrm{~V},+17 \mathrm{~V}\)
V \(_{\text {RFB }}\) to GND . . . . . . . . . . . . . . . . . . . . . . \(\pm 25 \mathrm{~V}\)
VREF to GND . . . . . . . . . . . . . . . . . . . . . . \(\pm 25 \mathrm{~V}\)
Digital Input Voltage to GND . . . -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
OUT1, OUT2 to GND . . . . . . . . -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
Power Dissipation (Any Package)
To \(+75^{\circ} \mathrm{C}\). . . . . . . . . . . . . . . . . . . 450 mW
Derates above \(75^{\circ} \mathrm{C}\) by . . . . . . . . . . . . . . . \(6 \mathrm{~mW} /{ }^{\circ} \mathrm{C}\)

Operating Temperature
Commerical (J, K, L) . . . . . . . . . . . \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
Industrial ( \(\mathrm{A}, \mathrm{B}, \mathrm{C}\) ) . . . . . . . . . . . . \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
Extended (S, T, U) . . . . . . . . . . . . \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
Storage Temperature . . . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Lead Temperature (Soldering, 10secs) . . . . . . . \(+300^{\circ} \mathrm{C}\)
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

\section*{CAUTION:}

ESD (Electro-Static-Discharge) sensitive device. The digital control inputs are Zener protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The foam should be discharged to the destination socket before devices are removed.

\section*{TERMINOLOGY}

RELATIVE ACCURACY: A measure of the deviation from a straight line through the end points of the DAC transfer function. Normally expressed as a percentage of full scale range. For the AD7524 DAC, this holds true over the entire \(\mathrm{V}_{\mathrm{REF}}\) range.

RESOLUTION: Value of the LSB. For example, a unipolar converter with \(n\) bits has a resolution of \(\left(2^{-n}\right)\left(V_{\text {REF }}\right)\). A bipolar converter of \(n\) bits has a resolution of [ \(2-(n-1)]\) [ \(\mathrm{V}_{\mathrm{REF}}\) ]. Resolution in no way implies linearity.

GAIN ERROR: Gain Error is a measure of the output error between an ideal DAC and the actual device output. It is
measured with all 1s in the DAC after offset error has been adjusted out and is expressed in LSBs. Gain Error is adjustable to zero with an external potentiometer.

FEEDTHROUGH ERROR: Error caused by capacitive coupling from \(V_{\text {REF }}\) to output with all switches OFF.

OUTPUT CAPACITANCE: Capacity from OUT1 and OUT2 terminals to ground.

OUTPUT LEAKAGE CURRENT: Current which appears on OUT1 terminal with all digital inputs LOW or on OUT2 terminal when all inputs are HIGH. This is an error current which contributes an offset voltage at the amplifier output.

\section*{PIN CONFIGURATIONS}


\section*{CIRCUIT DESCRIPTION}

\section*{CIRCUIT INFORMATION}

The AD7524, an 8-bit multiplying D/A converter, consists of a highly stable thin film R-2R ladder and eight N-channel current switches on a monolithic chip. Most applications require the addition of only an output operational amplifier and a voltage or current reference.
The simplified D/A circuit is shown in Figure 1. An inverted \(R-2 R\) ladder structure is used - that is, the binarily weighted currents are switched between the OUT1 and OUT2 bus lines, thus maintaining a constant current in each ladder leg independent of the switch state.


Figure 1. AD7524 Functional Diagram

\section*{EQUIVALENT CIRCUIT ANALYSIS}

The equivalent circuit for all digital inputs LOW is shown in Figures 2. In Figure 2 with all digital inputs LOW, the reference current is switched to OUT2. The current source I LEAKAGE is composed of surface and junction leakages to the substrate while the \(\frac{1}{256}\) current source represents a constant 1 -bit current drain through the termination resistor on the R-2R ladder. The "ON" capacitance of the output N-channel switches is 120 pF , as shown on the OUT2 terminal. The "OFF" switch capacitance is 30 pF , as shown on the OUT1 terminal. Analysis of the circuit for all digital inputs high is similar to Figure 2 however, the "ON" switches are now on terminal OUT1, hence the 120 pF appears at that terminal.


Figure 2. AD7524 DAC Equivalent Circuit - All Digita! Inputs Low

\section*{INTERFACE LOGIC INFORMATION}

MODE SELECTION
AD7524 mode selection is controlled by the \(\overline{\mathrm{CS}}\) and \(\overline{W R}\) inputs.

\section*{WRITE MODE}

When \(\overline{\text { CS }}\) and \(\overline{W R}\) are both LOW, the AD7524 is in the WRITE mode, and the AD7524 analog output responds to data activ-
ity at the DB0-DB7 data bus inputs. In this mode, the AD7524 acts like a nonlatched input D/A converter.

\section*{HOLD MODE}

When either CS or \(\overline{\text { WR }}\) is HIGH, the AD7524 is in the HOLD mode. The AD7524 analog ou tput holds the value corresponding to the last digital input present at DB0-DB7 prior to WR or CS assuming the HIGH state.

MODE SELECTION TABLE
\begin{tabular}{|c|c|c|l|}
\hline\(\overline{\mathbf{C S}}\) & \(\overline{\text { WR }}\) & MODE & \multicolumn{1}{|c|}{ DAC RESPONSE } \\
\hline L & L & Write & \begin{tabular}{l} 
DAC responds to data bus \\
(DB0 - DB7) inputs
\end{tabular} \\
\hline H & \(\mathbf{X}\) & Hold & \begin{tabular}{l} 
Data bus (DB0 - DB7) is \\
locked out;
\end{tabular} \\
\hline \(\mathbf{X}\) & \(\mathbf{H}\) & Hold & \begin{tabular}{l} 
DAC holds last data present \\
when \(\overline{W R}\) or \(\overline{\mathrm{CS}}\) assumed \\
HIGH state.
\end{tabular} \\
\hline
\end{tabular}

L = Low State, H = High State, X = Don't Care.

\section*{WRITE CYCLE TIMING DIAGRAM}


\section*{NOTES:}
1. All input signal rise and fall times measured from \(10 \%\) to \(90 \%\) of \(V_{D D}\). \(V_{D D}=+5 V, t_{r}=t_{f}=20 \mathrm{~ns}\);
\(V_{D D}=+15 \mathrm{~V}, \mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=40 \mathrm{~ns}\).
2. Timing Measurement Reference level is \(\frac{V_{I H}+V_{1 L}}{2}\)
3. tDS \(+{ }^{\text {t }} \mathrm{DH}\) is approximately constant at 145 ns min at \(+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V}\) and \(\mathrm{t}_{\mathrm{wr}}=170 \mathrm{~ns} \mathrm{~min}\). The AD7524 is specified for a minimum tDH of 10 ns , however, in applications where tDH \(>10 \mathrm{~ns}\), tDS may be reduced accordingly up to the limit tos \(=\) \(65 n s, \mathrm{t}_{\mathrm{DH}}=80 \mathrm{~ns}\).


Figure 3. Supply Current vs. Logic Level
Typical plots of supply current, \(I_{D D}\), versus logic input voltage, \(V_{I N}\), for \(V_{D D}=+5 \mathrm{~V}\) and \(V_{D D}=+15 \mathrm{~V}\) are shown above. CMOS Dual 8-Bit Buffered Multiplying DAC

FEATURES
On-Chip Latches for Both DACs
+5 V to +15 V Operation
DACs Matched to 1\%
Four Quadrant Multiplication

\section*{TTLCMOS Compatible}

Latch Free (Protection Schottkys not Required)
APPLICATIONS
Digital Control of: Gain/Attenuation
Filter Parameters
Stereo Audio Circuits
X-Y Graphics

\section*{GENERAL DESCRIPTION}

The AD7528 is a monolithic dual 8-bit digital/analog converter featuring excellent DAC-to-DAC matching. It is available in skinny \(0.3^{\prime \prime}\) wide 20 -pin DIPs and in 20 -terminal surface mount packages.
Separate on-chip latches are provided for each DAC to allow easy microprocessor interface.
Data is transferred into either of the two DAC data latches via a common 8-bit TTL/CMOS compatible input port. Control input \(\overline{\mathrm{DAC} \mathrm{A}} / \mathrm{DAC} \mathrm{B}\) determines which DAC is to be loaded. The AD7528's load cycle is similar to the write cycle of a random access memory and the device is bus compatible with most 8 -bit microprocessors, including 6800, 8080, 8085, Z80.

The device operates from a +5 V to +15 V power supply, dissipating only 20 mW of power.

Both DACs offer excellent four quadrant multiplication characteristics with a separate reference input and feedback resistor for each DAC.

FUNCTIONAL BLOCK DIAGRAM


\section*{PRODUCT HIGHLIGHTS}
1. DAC to DAC matching: since both of the AD7528 DACs are fabricated at the same time on the same chip, precise matching and tracking between DAC A and DAC B is inherent. The AD7528's matched CMOS DACs make a whole new range of applications circuits possible, particularly in the audio, graphics and process control areas.
2. Small package size: combining the inputs to the on-chip DAC latches into a common data bus and adding a \(\overline{\mathrm{DAC}} \mathrm{A} /\) DAC B select line has allowed the AD7528 to be packaged in either a small 20-pin DIP, SOIC, PLCC or LCCC.

AD7528
-SPECIFICATIONS
\(\left(V_{\text {REF }} A=V_{\text {REF }} B=+10 V\right.\); OUT \(A=O U T B=O V\) unless otherwise specified)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|}
\hline Parameter & Versioa \({ }^{1}\) & \multicolumn{2}{|l|}{\[
\begin{gathered}
V_{D D}=+5 V \\
T_{A}=+25^{\circ} \mathrm{C} \quad T_{m a n}, T_{\max }
\end{gathered}
\]} & \multicolumn{2}{|l|}{\(V_{\text {DD }}=+15 \mathrm{~V}\)} & Units & Test Coaditiona/Comments & \(\because\) \\
\hline \multicolumn{9}{|l|}{STATICPERFORMANCE \({ }^{\mathbf{2}}\)} \\
\hline Resolution & All & 8 & 8 & 8 & 8 & Bits & & \\
\hline \multirow[t]{3}{*}{Relative Accuracy} & J, A, S & \(\pm 1\) & \(\pm 1\) & \(\pm 1\) & \(\pm 1\) & LSB max & This is an Endpoint Linearity Specification & \\
\hline & K, B, T & \(\pm 1 / 2\) & \(\pm 1 / 2\) & \(\pm 1 / 2\) & \(\pm 1 / 2\) & LSB max & & \\
\hline & L,C,U & \(\pm 1 / 2\) & \(\pm 1 / 2\) & \(\pm 1 / 2\) & \(\pm 1 / 2\) & LSB max & & \\
\hline Differential Nonlinearity & All & \(\pm 1\) & \(\pm 1\) & \(\pm 1\) & \(\pm 1\) & LSB max & All Grades Guaranteed Monotonic Over Full Operating Temperature Range & \\
\hline \multirow[t]{3}{*}{Gain Error} & J, A, S & \(\pm 4\) & \(\pm 6\) & \(\pm 4\) & \(\pm 5\) & LSB max & Measured Using Internal RFB A and RFB B. & \\
\hline & K, B, T & \(\pm 2\) & \(\pm 4\) & \(\pm 2\) & \(\pm 3\) & LSB max & Both DAC Latches Loaded with 11111111 . & \\
\hline & L, C, U & \(\pm 1\) & \(\pm 3\) & \(\pm 1\) & \(\pm 1\) & & Gain Error is Adjustable Using Circuits of Figures 4 and 5. & \\
\hline \multicolumn{9}{|l|}{Gain Temperature Coefficient \({ }^{4}\)} \\
\hline \(\Delta \mathrm{Gain} / \Delta T\) emperature & All & \(\pm 0.007\) & \(\pm 0.007\) & \(\pm 0.0035\) & \(\pm 0.0035\) & \% \({ }^{\circ} \mathrm{C}\) max & & \\
\hline \multicolumn{9}{|l|}{Output Leakage Current} \\
\hline OUTA (Pin 2) & All & \(\pm 50\) & \(\pm 400\) & \(\pm 50\) & \(\pm 200\) & \(n A\) max & DAC Latches Loaded with 00000000 & \\
\hline OUT B (Pin 20) & All & \(\pm 50\) & \(\pm 400\) & \(\pm 50\) & \(\pm 200\) & \(n A_{\text {max }}\) & & \\
\hline \multirow[t]{2}{*}{Input Resistance ( \(\mathbf{V}_{\text {REF }} \mathbf{A}, \mathbf{V}_{\text {REF }} \mathbf{B}\) )} & All & 8 & & & & \(\mathrm{k} \Omega\) min & Input Resistance \(\mathrm{TC}=-\mathbf{3 0 0} \mathrm{ppm} /{ }^{\circ} \mathrm{C}\), Typical & \\
\hline & & 15 & 15 & 15 & 15 & \(\mathbf{k} \Omega_{\text {max }}\) & Input Resistance is \(11 \mathbf{k \Omega}\) & \\
\hline \(\mathbf{V}_{\text {REF }} \mathbf{A} \mathbf{V}_{\text {REF }} \mathbf{B}\) Input Resistance Match & All & \(\pm 1\) & \(\pm 1\) & \(\pm 1\) & \(\pm 1\) & \% max & & \\
\hline \multicolumn{9}{|l|}{DIGITAL INPUTS \({ }^{3}\)} \\
\hline Input High Voltage & & & & & & & & \\
\hline \(\stackrel{V_{\text {IH }}}{ }\) & All & 2.4 & 2.4 & 13.5 & 13.5 & \(V_{\text {min }}\) & & \\
\hline \multicolumn{9}{|l|}{Input Low Voltage} \\
\hline Input Current & & & & & & & & \\
\hline \(\mathrm{I}_{\mathbf{i N}}\) & All & \(\pm 1\) & \(\pm 10\) & \(\pm 1\) & \(\pm 10\) & \(\mu \mathrm{A}\) max & \(\mathrm{V}_{\mathrm{IN}}=0\) or \(\mathrm{V}_{\mathrm{DD}}\) & \\
\hline \multicolumn{9}{|l|}{Input Capacitance} \\
\hline DB0-DB7 & All & 10 & 10 & 10 & 10 & pF max & & \\
\hline \(\overline{\text { WR }}, \overline{\mathrm{CS}}, \overline{\mathrm{DACA}} / \mathrm{DACB}\) & All & 15 & 15 & 15 & 15 & pF max & & \\
\hline \multicolumn{7}{|l|}{SWITCHING CHARACTERISTICS \({ }^{4}\)} & See Timing Diagram & \\
\hline \multicolumn{9}{|l|}{Chip Select to Write Set Up Time} \\
\hline \({ }^{\text {tcs }}\) & All & 200 & 230 & 60 & 80 & ns min & & \\
\hline \multicolumn{9}{|l|}{Chip Select to Write Hold Time} \\
\hline \multicolumn{9}{|l|}{DAC Select to Write Set Up Time} \\
\hline \({ }_{\text {DAC Select to }}{ }^{\text {t/ss }}\) Write Hold Time & All & 200 & 230 & 60 & 80 & ns min & \(\because\) & \\
\hline \multicolumn{9}{|l|}{} \\
\hline \({ }_{\text {Data Valid to Write Hold Time }}{ }_{\text {D }}\) & All & 110 & 130 & 30 & 40 & ns min & & \\
\hline \multicolumn{9}{|l|}{} \\
\hline \({ }_{\text {t }}^{\text {WR }}\) & All & 180 & 200 & 60 & 80 & ns min & & \\
\hline \multicolumn{7}{|l|}{POWER SUPPLY} & See Figure 3 & \\
\hline \multirow[t]{2}{*}{\(\mathrm{I}_{\mathrm{DD}}\)} & All & 2 & 2 & 2 & 2 & mA max & All Digital Inputs \(\mathrm{V}_{\text {IL }}\) or \(\mathrm{V}_{\text {IH }}\) & \\
\hline & All & 100 & 500 & 100 & 500 & \(\mu \mathrm{A}\) max & All Digital Inputs 0 V or \(\mathrm{V}_{\text {DD }}\) & \\
\hline
\end{tabular}

\section*{}
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline Parameter & Version \({ }^{1}\) & \[
\begin{gathered}
\mathbf{V}_{\mathrm{DD}}=+5 \\
\mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}
\end{gathered}
\] & \[
\begin{aligned}
& 5 \mathbf{V} \\
& \mathbf{T}_{\min }, \mathbf{T}_{\text {max }}
\end{aligned}
\] & \[
\begin{gathered}
\mathrm{V}_{\mathrm{DD}}=+15 \\
\mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}
\end{gathered}
\] & \[
\stackrel{\mathbf{5 V}}{\mathbf{T}_{\text {min }}, \mathbf{T}_{\text {max }}}
\] & Units & Test Conditions/Comments \\
\hline DCSUPPLY REJECTION ( \(\triangle\) GAIN/ \(\Delta \mathrm{V}_{\text {DD }}\) ) & All & 0.02 & 0.04 & 0.01 & 0.02 & \% per \% max & \(\Delta V_{\text {DD }}= \pm 5 \%\) \\
\hline CURRENT SETTLING TIME \({ }^{2}\) & All & 350 & 400 & 180 & 200 & ns max & \[
\begin{aligned}
& \text { To } 1 / 2 \text { LSB. Out A/Out B load }=100 \Omega . \\
& \overline{\mathrm{WR}}=\overline{\mathrm{CS}}=0 \mathrm{~V} . \mathrm{DB} 0-\mathrm{DB} 7=0 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{DD}} \text { or } \mathrm{V}_{\mathrm{DD}} \text { to } 0 \mathrm{~V}
\end{aligned}
\] \\
\hline PROPAGATION DELAY (From Digital Input to \(90 \%\) of Final Analog Output Current) & All & 220 & 270 & 80 & 100 & ns max & \[
\begin{aligned}
& \mathrm{V}_{\text {REF }} \mathrm{A}=\mathrm{V}_{\text {REF }} \mathrm{B}=+10 \mathrm{~V} \\
& \text { OUTA, } \\
& \text { OUT }, \mathrm{CS}=0 \mathrm{~V} \text { Load }=100 \Omega \mathrm{C}_{\mathrm{EXT}}=13 \mathrm{pF} \\
& \mathrm{WR}, \mathrm{DB} 7=0 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{DD}} \text { or } \mathrm{V}_{\mathrm{DD}} \text { to } 0 \mathrm{~V}
\end{aligned}
\] \\
\hline DIGITAL TO ANALOG GLITCH IMPULSE & All & 160 & - & 440 & - & nV sec typ & For Code Transition 00000000 to 11111111 \\
\hline OUTPUT CAPACITANCE & & & & & & & \\
\hline Cout A & All & 50 & 50 & 50 & 50 & pF max & DAC Latches Loaded with 00000000 \\
\hline Cout \({ }^{\text {B }}\) & & 50 & 50 & 50 & 50 & pF max &  \\
\hline \(\mathrm{Cout}^{\text {A }}\) & & 120 & 120 & 120 & 120 & pF max & DAC Latches Loaded with 11111111 \\
\hline Cout \({ }^{\text {B }}\) & & 120 & 120 & 120 & 120 & pF max & \\
\hline ACFEEDTHROUGH \({ }^{6}\) & & & & & & & \\
\hline \(\mathrm{V}_{\text {REF }} \mathrm{A}\) to OUT A & All & -70 & -65 & -70 & -65 & \(\mathrm{dB}_{\text {max }}\) & \(\mathrm{V}_{\text {REF }} \mathrm{A}, \mathrm{V}_{\text {REF }} \mathrm{B}=20 \mathrm{~V}\) p-p Sine Wave \\
\hline \(\mathrm{V}_{\text {REF }}\) B to OUT B & & -70 & -65 & -70 & -65 & \(\mathrm{dB}_{\text {max }}\) & @ 100 kHz \\
\hline CHANNEL TOCHANNEL ISOLATION \(V_{\text {REF }} A\) to OUTB & All & -77 & - & -77 & - & dB typ & Both DAC Latches Loaded with 11111111. \(\mathbf{V}_{\text {REF }} \mathrm{A}=\mathbf{2 0 V} \mathbf{p - p}\) Sine Wave @ 100 kHz \(V_{\text {REF }} B=0 \mathrm{~V}\) see Figure 6. \\
\hline \(\mathrm{V}_{\text {REF }} \mathrm{B}\) to OUT A & & -77 & - & -77 & - & dB typ & \[
\begin{aligned}
& \mathrm{V}_{\text {REF }} \mathrm{A}=20 \mathrm{~V} \text { p-p Sine Wave @ } 100 \mathrm{kHz} \\
& \mathrm{~V}_{\text {REF }} \mathrm{A}=0 \mathrm{~V} \text { see Figure } 6 .
\end{aligned}
\] \\
\hline DIGITAL CROSSTAIK & All & 30 & - & 60 & - & nV sectyp & Measured for Code Transition 00000000 to 11111111 \\
\hline HARMONIC DISTORTION & All & -85 & - & -85 & - & dB typ & \(\mathrm{V}_{\mathbf{I N}}=6 \mathrm{~V}\) rms @ 1 kHz \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Temperature Ranges are J, K, L Versions: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
A, B, CVersions: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
S, T, U Versions: \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
\({ }^{2}\) Specification applies to both DACs in AD7528.
\({ }^{3}\) Logic inputs are MOS Gates. Typical input current \(\left(+25^{\circ} \mathrm{C}\right)\) is less than \(\ln \mathrm{A}\)
\({ }^{4}\) Guaranteed by design but not production tested.
\({ }^{\text {S }}\) These characteristics are for design guidance only and are not subject to test.
\({ }^{6}\) Feedthrough can be further reduced by connecting the metal lid on the ceramic package (suffix D) to DGND.
Specifications subject to change without notice.

\section*{ABSOLUTE MAXIMUM RATINGS}
( \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) unless otherwise noted)


\section*{CAUTION:}
1. ESD sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subjected to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts.
2. Do not insert this device into powered sockets. Remove power before insertion or removal.

\section*{TERMINOLOGY}

\section*{Relative Accuracy:}

Relative accuracy or endpoint nonlinearity is a measure of the maximum deviation from a straight line passing through the endpoints of the DAC transfer function. It is measured after adjusting for zero and full scale and is normally expressed in LSBs or as a percentage of full scale reading.

\section*{ORDERING GUIDE \({ }^{\mathbf{1}}\)}
\begin{tabular}{|c|c|c|c|c|}
\hline Model \({ }^{2}\) & Temperature Range & \begin{tabular}{l}
Relative \\
Accuracy
\end{tabular} & \begin{tabular}{l}
Gain \\
Error
\end{tabular} & Package Option \({ }^{3}\) \\
\hline AD7528JN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\pm 4 \mathrm{LSB}\) & N-20 \\
\hline AD7528KN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2\) LSB & \(\pm 2 \mathrm{LSB}\) & N-20 \\
\hline AD7528LN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2\) LSB & \(\pm 1 \mathrm{LSB}\) & N-20 \\
\hline AD7528JP & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\pm 4 \mathrm{LSB}\) & P-20A \\
\hline AD7528KP & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2\) LSB & \(\pm 2 \mathrm{LSB}\) & P-20A \\
\hline AD7528LP & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\pm 1 \mathrm{LSB}\) & P-20A \\
\hline AD7528JR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1\) LSB & \(\pm 4 \mathrm{LSB}\) & R-20 \\
\hline AD7528KR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2\) LSB & \(\pm 2 \mathrm{LSB}\) & R-20 \\
\hline AD7528LR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2\) LSB & \(\pm 1\) LSB & R-20 \\
\hline AD7528AQ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1\) LSB & \(\pm 4 \mathrm{LSB}\) & Q-20 \\
\hline AD7528BQ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2\) LSB & \(\pm 2 \mathrm{LSB}\) & Q-20 \\
\hline AD7528CQ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\pm 1 \mathrm{LSB}\) & Q-20 \\
\hline AD7528SQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\pm 4 \mathrm{LSB}\) & Q-20 \\
\hline AD7528TQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 / 2\) LSB & \(\pm 2 \mathrm{LSB}\) & Q-20 \\
\hline AD7528UQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\pm 1\) LSB & Q-20 \\
\hline AD7528SE & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1\) LSB & \(\pm 4 \mathrm{LSB}\) & E-20A \\
\hline AD7528TE & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\pm 2 \mathrm{LSB}\) & E-20A \\
\hline AD7528UE & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\pm 1 \mathrm{LSB}\) & E-20A \\
\hline
\end{tabular}

\footnotetext{
NOTES
\({ }^{1}\) Analog Devices reserves the right to ship side-brazed ceramic in lieu of cerdip. Parts will be marked with cerdip designator " Q ."
\({ }^{2}\) Processing to MIL-STD-883C, Class B is available. To order, add suffix "/883B" to part number. For further information, see Analog Devices' 1990 Military Products Databook. \({ }^{3} \mathrm{E}=\) Leadless Ceramic Chip Carrier; \(\mathrm{N}=\) Plastic DIP; \(\mathbf{P}=\) Plastic Leaded Chip Carrier; \(\mathbf{Q}=\) Cerdip; \(\mathbf{R}=\) SOIC. For outline information see Package Information section.
}

\section*{Differential Nonlinearity:}

Differential nonlinearity is the difference between the measured change and the ideal 1LSB change between any two adjacent codes. A specified differential nonlinearity of \(\pm 1\) LSB max over the operating temperature range ensures monotonicity.

\section*{Gain Error:}

Gain error or full-scale error is a measure of the output error between an ideal DAC and the actual device output. For the AD7528, ideal maximum output is \(\mathrm{V}_{\mathrm{REF}}-1 L S B\). Gain error of both DACs is adjustable to zero with external resistance.

\section*{Output Capacitance:}

Capacitance from OUT A or OUT B to AGND.

\section*{Digital to Analog Glitch Impulse:}

The amount of charge injected from the digital inputs to the analog output when the inputs change state. This is normally specified as the area of the glitch in either pA -secs or nV -secs depending upon whether the glitch is measured as a current or voltage signal. Glitch impulse is measured with \(\mathrm{V}_{\text {REF }} \mathrm{A}, \mathrm{V}_{\text {REF }} \mathrm{B}=\mathrm{AGND}\).

\section*{Propagation Delay:}

This is a measure of the internal delays of the circuit and is defined as the time from a digital input change to the analog output current reaching \(90 \%\) of its final value.

\section*{Channel-to-Channel Isolation:}

The proportion of input signal from one DAC's reference input which appears at the output of the other DAC, expressed as a ratio in dB.

\section*{Digital Crosstalk:}

The glitch energy transferred to the output of one converter due to a change in digital input code to the other converter. Specified in nV secs.

\section*{PIN CONFIGURATIONS}


\section*{INTERFACE LOGIC INFORMATION}

\section*{DAC Selection:}

Both DAC latches share a common 8-bit input port. The control input DAC A /DAC B selects which DAC can accept data from the input port.

\section*{Mode Selection:}

Inputs \(\overline{\mathrm{CS}}\) and \(\overline{\mathrm{WR}}\) control the operating mode of the selected DAC. See Mode Selection Table below.

\section*{Write Mode:}

When \(\overline{\mathrm{CS}}\) and \(\overline{\mathrm{WR}}\) are both low the selected DAC is in the write mode. The input data latches of the selected DAC are transparent and its analog output responds to activity on DB0DB7.

\section*{Hold Mode:}

The selected DAC latch retains the data which was present on DB0-DB7 just prior to \(\overline{\mathrm{CS}}\) or \(\overline{\mathrm{WR}}\) assuming a high state. Both analog outputs remain at the values corresponding to the data in their respective latches.
\begin{tabular}{l|l|l|l|l}
\(\overline{\text { DACA/ }}\) & & & \\
DACB & \(\overline{\text { CS }}\) & \(\overline{\text { WR }}\) & DACA & DACB \\
\hline L & L & L & WRITE & HOLD \\
H & L & L & HOLD & WRITE \\
X & H & X & HOLD & HOLD \\
X & X & H & HOLD & HOLD \\
\hline
\end{tabular}
\(\mathrm{L}=\) Low State \(\mathrm{H}=\) High State \(\mathrm{X}=\) Don't Care
Mode Selection Table

\section*{WRITE CYCLE TIMING DIAGRAM}


\section*{CIRCUIT INFORMATION-D/A SECTION}

The AD7528 contains two identical 8-bit multiplying D/A converters, DAC A and DAC B. Each DAC consists of a highly stable thin film R-2R ladder and eight N -channel current steering switches. A simplified D/A circuit for DAC A is shown in Figure 1. An inverted \(\mathrm{R}-2 \mathrm{R}\) ladder structure is used, that is, binary weighted currents are switched between the DAC output and AGND thus maintaining fixed currents in each ladder leg independent of switch state.


Figure 1. Simplified Functional Circuit for DACA

\section*{EQUIVALENT CIRCUIT ANALYSIS}

Figure 2 shows an approximate equivalent circuit for one of the AD7528's D/A converters, in this case DAC A. A similar equivalent circuit can be drawn for DAC B. Note that AGND (Pin 1) is common for both DAC A and DAC B.
The current source \(I_{\text {LeAKAGE }}\) is composed of surface and junction leakages and, as with most semiconductor devices, approximately doubles every \(10^{\circ} \mathrm{C}\). The resistor \(\mathrm{R}_{\mathrm{O}}\) as shown in Figure 2 is the equivalent output resistance of the device which varies with input code (excluding all 0 's code) from \(0.8 R\) to \(2 R\). \(R\) is typically \(11 \mathrm{k} \Omega\). Cout is the capacitance due to the N -channel switches and varies from about 50 pF to 120 pF depending upon the digital input. \(g\left(V_{\text {REF }} A, N\right)\) is the Thevenin equivalent voltage generator due to the reference input voltage \(\mathrm{V}_{\text {REF }} \mathrm{A}\) and the transfer function of the R-2R ladder.


Figure 2. Equivalent Analog Output Circuit of DAC A
For further information on CMOS multiplying \(\mathrm{D} / \mathrm{A}\) converters refer to "Appplication Guide to CMOS Multiplying D/A Converters" available from Analog Devices, Publication Number G479-15-8/78.

\section*{CIRCUIT INFORMATION-DIGITAL SECTION}

The input buffers are simple CMOS inverters designed such that when the AD7528 is operated with \(\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}\), the buffer converts TTL input levels ( 2.4 V and 0.8 V ) into CMOS logic levels. When \(\mathrm{V}_{\mathrm{IN}}\) is in the region of 2.0 volts to 3.5 volts the input buffers operate in their linear region and pass a quiescent current, see Figure 3. To minimize power supply currents it is recommended that the digital input voltages be as close to the supply rails ( \(V_{D D}\) and DGND ) as is practically possible.
The AD7528 may be operated with any supply voltage in the range \(5 \leq \mathrm{V}_{\mathrm{DD}} \leq 15\) volts. With \(\mathrm{V}_{\mathrm{DD}}=+15 \mathrm{~V}\) the input logic levels are CMOS compatible only, i.e., 1.5 V and 13.5 V .


Figure 3. Typical Plots of Supply Current, IDD vs. Logic Input Voltage \(V_{I N}\), for \(V_{D D}=+5 \mathrm{~V}\) and +15 V

\section*{FEATURES}

Two 12-Bit DACs in One Package
DAC Ladder Resistance Matching: 0.5\%
Space Saving Skinny DIP and Surface Mount Packages 4-Quadrant Multiplication
Low Gain Error (1LSB max Over Temperature) Byte Loading Structure

\section*{Fast Interface Timing}

\section*{APPLICATIONS}

\section*{Automatic Test Equipment}

Programmable Filters

\section*{Audio Applications}

\section*{Synchro Applications}

\section*{Process Control}

\section*{GENERAL DESCRIPTION}

The AD7537/AD7547 contains two 12-bit current output DACs on one monolithic chip. Also on-chip are the level shifters, data registers and control logic for easy microprocessor interfacing. There are 12 data inputs. The AD7537 has a 2-byte loading structure making it compatible with 8 -bit processor systems. The AD7547 has a 12 -bit parallel loading structure for use in 16-bit systems.
The D/A converters provide 4-quadrant multiplication capabilities with separate reference inputs and feedback resistors. Monolithic construction ensures that thermal and gain error tracking is excellent. Twelve-bit monotonicity is guaranteed for both DACs over the full temperature range.
The DACs are manufactured using the Linear Compatible CMOS (LC \({ }^{2}\) MOS) process. This allows fast digital logic and precision linear circuitry to be fabricated on the same die.

\section*{PRODUCT HIGHLIGHTS}

\section*{1. DAC to DAC Matching}

Since both DACs are fabricated on the same chip, precise matching and tracking is inherent. Many applications which are not practical using two discrete DACs are now possible. Typical matching: \(0.5 \%\).
2. Wide Power Supply Tolerance

The device operates on \(\mathrm{a}+12 \mathrm{~V}\) to \(+15 \mathrm{~V} \mathrm{~V}_{\mathrm{DD}}\), with \(\pm 10 \%\) tolerance on this nominal figure. All specifications are guaranteed over this range.

AD7537 FUNCTIONAL BLOCK DIAGRAM


AD7547 FUNCTIONAL BLOCK DIAGRAM




\section*{AC PERFORMANCE CHARACTERISTICS}

These characteristics are included for Design Guidance only and are not subject to test.
\(\left(V_{D D}=+12 \mathrm{~V}\right.\) to \(+15 \mathrm{~V} ; \mathrm{V}_{\text {REFA }}=\mathrm{V}_{\text {REFB }}=+10 \mathrm{~V}, \mathrm{I}_{\text {OUTA }}=\mathrm{I}_{\mathrm{OUTB}}=\) AGND \(=0 \mathrm{~V}\). Output Amplifiers are AD644 except where stated. \()\)
\begin{tabular}{|c|c|c|c|c|}
\hline Parameter & \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) & \(\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {min }}, \mathrm{T}_{\text {max }}\) & Units & Test Conditions/Comments \\
\hline Output Current Settling Time & 1.5 & - & \(\mu \mathrm{s}\) max & To \(0.01 \%\) of full-scale range. \(\mathrm{I}_{\text {OUT }}\) load \(=100 \Omega, \mathrm{C}_{\mathrm{EXT}}=13 \mathrm{pF}\). DAC output measured from rising edge of \(\bar{W} R\). Typical Value of Settling Time is \(0.8 \mu \mathrm{~s}\). \\
\hline Digital-to-Analog Glitch Impulse & 7 & - & nV-s typ & Measured with \(\mathrm{V}_{\text {REFA }}=\mathrm{V}_{\text {REFB }}=0 \mathrm{~V}\). I OUTA , \(\mathrm{I}_{\text {OUTB }}\) load \(=100 \Omega, \mathrm{C}_{\text {EXT }}=13 \mathrm{pF}\). DAC registers alternately loaded with all 0's and all l's. \\
\hline AC Feedthrough \({ }^{4}\) \(V_{\text {Refa }}\) to \(I_{\text {Outa }}\) \(\mathrm{V}_{\text {REFB }}\) to \(\mathrm{I}_{\text {OutB }}\) & \[
\begin{array}{r}
-70 \\
-70
\end{array}
\] & \[
\begin{array}{r}
-65 \\
-65 \\
\hline
\end{array}
\] & dB max dB max & \(\mathbf{V}_{\text {REFA }}, \mathrm{V}_{\text {REFB }}=20 \mathrm{~V}\) p-p 10kHz sinewave. DAC registers loaded with all 0 's. \\
\hline Power Supply Rejection \(\Delta \mathrm{Gain} / \Delta \mathrm{V}_{\mathrm{DD}}\) & \(\pm 0.01\) & \(\pm 0.02\) & \% per \% max & \(\Delta V_{D D}=V_{\text {DD }} \max -V_{D D}\) min \\
\hline \begin{tabular}{l}
Output Capacitance \\
Couta \\
Coutb \\
Couta \\
Coutb
\end{tabular} & \[
\begin{aligned}
& 70 \\
& 70 \\
& 140 \\
& 140
\end{aligned}
\] & \[
\begin{aligned}
& 70 \\
& 70 \\
& 140 \\
& 140
\end{aligned}
\] & pF max pF max pF max pF max & \begin{tabular}{l}
DAC A, DACB loaded with all 0's. \\
DAC A, DAC B loaded with all l's.
\end{tabular} \\
\hline \begin{tabular}{l}
Channel-to-Channel Isolation \\
\(\mathrm{V}_{\text {REFA }}\) to \(\mathrm{I}_{\text {OUTB }}\) \\
\(\mathrm{V}_{\text {REFB }}\) to \(\mathrm{I}_{\text {OUTA }}\)
\end{tabular} & -84
-84 & - & \begin{tabular}{l}
dB typ \\
dB typ
\end{tabular} & \begin{tabular}{l}
\(\mathrm{V}_{\text {REFA }}=20 \mathrm{~V}\) p-p 10 kHz sinewave, \(\mathrm{V}_{\text {REFB }}=0 \mathrm{~V}\). \\
Both DACs loaded with all l's. \\
\(\mathrm{V}_{\mathrm{REFB}}=20 \mathrm{~V}\) p-p 10 kHz sinewave, \(\mathrm{V}_{\mathrm{REFA}}=0 \mathrm{~V}\). \\
Both DACs loaded with all 1's.
\end{tabular} \\
\hline Digital Crosstalk & 7 & - & nV-s typ & Measured for a Code Transition of all 0's to all 1's. \(\bar{I}_{\text {OUTA }}, \bar{I}_{\text {OUTB }}\) Load \(=100 \Omega \bar{L}, C_{\text {EXT }}=13 \mathrm{pF}\) \\
\hline Output Noise Voltage Density ( \(10 \mathrm{~Hz}-100 \mathrm{kHz}\) ) & 25 & - & \(\mathrm{nV} / \sqrt{\mathrm{Hz}}\) typ & Measured between \(\mathrm{R}_{\text {FBA }}\) and \(\mathrm{I}_{\text {OUTA }}\) or \(\mathrm{R}_{\text {FBB }}\) and \(\mathrm{I}_{\text {OUTB }}\). Frequency of measurement is \(10 \mathrm{~Hz}-100 \mathrm{kHz}\). \\
\hline Total Harmonic Distortion & -82 & - & dB typ & \(\mathrm{V}_{\text {IN }}=6 \mathrm{~V}\) rms, 1 kHz . Both DACs loaded with all 1's. \\
\hline
\end{tabular}

NOTES
\({ }^{\prime}\) Temperature range as follows: \(\mathrm{J}, \mathrm{K}, \mathrm{L}\) Versions: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\).
A, B, C Versions: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\).
\(\mathrm{S}, \mathrm{T}, \mathrm{U}\) Versions: \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\).
\({ }^{2}\) Sample tested at \(25^{\circ} \mathrm{C}\) to ensure compliance.
\({ }^{3}\) Functional at \(V_{D D}=5 V\) with degraded specifications.
\({ }^{4}\) Pin 12 (DGND) on ceramic DIPs is connected to lid.
Specifications subject to change without notice.

AD7537 TIMING CHARACTERISTICS \(\left(V_{D D}=10.8 \mathrm{~V}\right.\) to \(\left.16.5 \mathrm{~V}, \mathrm{~V}_{\text {REFA }}=\mathrm{V}_{\text {REFB }}=+10 \mathrm{~V}, \mathrm{I}_{\text {OUTA }}=A G N D A=0 \mathrm{~V}, \mathrm{I}_{\text {OUtB }}=A G N D B=0 \mathrm{~V}\right)\).
\begin{tabular}{|c|c|c|c|c|c|}
\hline Parameter & Limit at
\[
\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}
\] & Limit at
\[
\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C}
\] & \[
\begin{aligned}
& \text { Limit at } \\
& \mathrm{T}_{\mathrm{A}}=+55^{\circ} \mathrm{C} \\
& \text { to }+125^{\circ} \mathrm{C}
\end{aligned}
\] & Units & Test Conditions/Comments \\
\hline \(\mathrm{t}_{1}\) & 15 & 15 & 30 & ns min & Address Valid to Write Setup Time \\
\hline \(\mathrm{t}_{2}\) & 15 & 15 & 25 & ns min & Address Valid to Write Hold Time \\
\hline \(\mathrm{t}_{3}\) & 60 & 80 & 80 & ns min & Data Setup Time \\
\hline \(t_{4}\) & 25 & 25 & 25 & ns min & Data Hold Time \\
\hline \(\mathrm{t}_{5}\) & 0 & 0 & 0 & ns min & Chip Select or Update to Write Setup Time \\
\hline \(t_{6}\) & 0 & 0 & 0 & ns min & Chip Select or Update to Write Hold Time \\
\hline \(\mathrm{t}_{7}\) & 80 & 80 & 100 & ns min & Write Pulse Width \\
\hline \(\mathrm{t}_{8}\) & 80 & 80 & 100 & ns min & Clear Pulse Width \\
\hline
\end{tabular}

Specifications subject to change without notice.

Table I. AD7537 Truth Table
\begin{tabular}{l|l|l|l} 
CSA & CSB & WR & \multicolumn{1}{|c}{ FUNCTION } \\
\hline \(\mathbf{X}\) & \(\mathbf{X}\) & \(\mathbf{1}\) & No Data Transfer \\
1 & 1 & \(\mathbf{X}\) & \begin{tabular}{l} 
No Data Transfer \\
A Rising Edge on \(\overline{\text { CSA }}\) or \(\overline{\text { CSB }}\) Loads
\end{tabular} \\
\(\mathbf{r}\) & \(\boldsymbol{r}\) & 0 & \begin{tabular}{l} 
Data to the Respective DAC from the Data Bus \\
DAC A Register Loaded from Data Bus \\
DAC B Register Loaded from Data Bus
\end{tabular} \\
\(\mathbf{0}\) & 1 & - & 0 \\
0 & 0 & - & \begin{tabular}{l} 
DAC A and DAC B Registers Loaded \\
from Data Bus
\end{tabular} \\
\hline
\end{tabular}

\section*{NOTES}
1. \(\mathrm{X}=\) Don't care
2. \(F\) means rising edge triggered


NOTES
. All INPUT SIGNAL RISE AND FALL TIMES MEASURED FROM \(10 \%\) TO \(90 \% \mathrm{OF}+5 \mathrm{~V} . \mathrm{t}_{\mathrm{t}}=\mathrm{t}_{\mathrm{t}}=20 \mathrm{~ns}\).
2. timing measurement reference Level is \(\frac{v_{w}+v_{u t}}{2}\)

Figure 1. Timing Diagram for AD7537

AD7537 ORDERING GUIDE \({ }^{1}\)
\begin{tabular}{l|l|l|l|l}
\hline Model \({ }^{2}\) & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Relative \\
Accuracy
\end{tabular} & \begin{tabular}{l} 
Gain \\
Error
\end{tabular} & \begin{tabular}{l} 
Package \\
Option \({ }^{3}\)
\end{tabular} \\
\hline AD7537JN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\pm 6 \mathrm{LSB}\) & \(\mathrm{N}-24\) \\
AD7537KN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\pm 3 \mathrm{LSB}\) & \(\mathrm{N}-24\) \\
AD7537LN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\pm 1 \mathrm{LSB}\) & \(\mathrm{N}-24\) \\
AD7537JP & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\pm 6 \mathrm{LSB}\) & \(\mathrm{P}-28 \mathrm{~A}\) \\
AD7537KP & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\pm 3 \mathrm{LSB}\) & \(\mathrm{P}-28 \mathrm{~A}\) \\
AD7537LP & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\pm 1 \mathrm{LSB}\) & \(\mathrm{P}-28 \mathrm{~A}\) \\
AD7537AQ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\pm 6 \mathrm{LSB}\) & \(\mathrm{Q}-24\) \\
AD7537BQ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\pm 3 \mathrm{LSB}\) & \(\mathrm{Q}-24\) \\
AD7537CQ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\pm 1 \mathrm{LSB}\) & \(\mathrm{Q}-24\) \\
AD7537SQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\pm 6 \mathrm{LSB}\) & \(\mathrm{Q}-24\) \\
AD7537TQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\pm 3 \mathrm{LSB}\) & \(\mathrm{Q}-24\) \\
AD7537UQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\pm 2 \mathrm{LSB}\) & \(\mathrm{Q}-24\) \\
AD7537SE & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\pm 6 \mathrm{LSB}\) & \(\mathrm{E}-28 \mathrm{~A}\) \\
AD7537TE & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\pm 3 \mathrm{LSB}\) & \(\mathrm{E}-28 \mathrm{~A}\) \\
AD7537UE & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\pm 2 \mathrm{LSB}\) & \(\mathrm{E}-28 \mathrm{~A}\) \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Analog Devices reserves the right to ship ceramic packages (D-24A) in lieu of cerdip packages (Q-24).
\({ }^{2}\) To order MIL-STD-883, Class B processed parts, add/883B to part number.
Contact your local sales office for military data sheet.
\({ }^{3} \mathrm{E}=\) Leadless Ceramic Chip Carrier; \(\mathbf{N}=\) Plastic DIP; \(\mathbf{P}=\) Plastic Leaded Chip Carrier; \(\mathbf{Q}=\) Cerdip. For outline information see Package Information section.

\begin{tabular}{|c|c|c|c|c|c|}
\hline Parameter & Limit at
\[
\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}
\] & Limit at
\[
\begin{aligned}
& \mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C} \\
& \text { to }+85^{\circ} \mathrm{C} \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \text { Limit at } \\
& \mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C} \\
& \text { to }+125^{\circ} \mathrm{C} \\
& \hline
\end{aligned}
\] & Units & Test Conditions/Comments \\
\hline \(t_{1}\) & 60 & 80 & 80 & ns min & Data Setup Time \\
\hline \(\mathrm{t}_{2}\) & 25 & 25 & 25 & ns min & Data Hold Time \\
\hline \(\mathrm{t}_{3}\) & 80 & 80 & 100 & ns min & Chip Select to Write Setup Time \\
\hline \(\mathrm{t}_{4}\) & 0 & 0 & 0 & ns min & Chip Select to Write Hold Time \\
\hline \(t_{5}\) & 80 & 80 & 100 & ns min & Write Pulse Width \\
\hline
\end{tabular}

Specifications subject to change without notice.

Table II. AD7547 Truth Table
\begin{tabular}{lllllll} 
CLR & UPD & CS & WR & A1 & A0 & FUNCTION \\
\hline \(\mathbf{1}\) & 1 & 1 & \(\mathbf{X}\) & \(\mathbf{X}\) & \(\mathbf{X}\) & \begin{tabular}{l} 
No Data Transfer \\
1
\end{tabular} \\
1 & \(\mathbf{X}\) & 1 & \(\mathbf{X}\) & \(\mathbf{X}\) & No Data Transfer \\
0 & \(\mathbf{X}\) & \(\mathbf{X}\) & \(\mathbf{X}\) & \(\mathbf{X}\) & \(\mathbf{X}\) & \begin{tabular}{l} 
All Registers Cleared \\
1
\end{tabular} \\
1 & 0 & 0 & 0 & 0 & \begin{tabular}{l} 
DACA LS Input Register \\
Loaded with DB7-DB0(LSB)
\end{tabular} \\
1 & 1 & 0 & 0 & 0 & 1 & \begin{tabular}{l} 
DACA MS Input Register \\
Loaded with DB3(MSB)-DB0
\end{tabular} \\
1 & 1 & 0 & 0 & 1 & 0 & \begin{tabular}{l} 
DACB LS Input Register \\
Loaded with DB7-DB0(LSB)
\end{tabular} \\
1 & 1 & 0 & 0 & 1 & 1 & \begin{tabular}{l} 
DACB MS Input Register \\
Loaded with DB3(MSB)-DB0
\end{tabular} \\
1 & 0 & 1 & 0 & \(\mathbf{X}\) & \(\mathbf{X}\) & \begin{tabular}{l} 
DACA, DACB Registers \\
Updated Simultaneously from
\end{tabular} \\
1 & 0 & 0 & 0 & \(\mathbf{X}\) & \(\mathbf{X}\) & \begin{tabular}{l} 
Input Registers \\
DACA, DACB Registers are \\
Transparent
\end{tabular} \\
\hline
\end{tabular}

NOTE: \(\mathrm{X}=\) Don't care


NOTES
1. ALL MPUT SIGNAL RISE AND FALL TMES MEASURED FROM \(10 \%\)

TO \(90 \%\) OF \(+5 V . t_{r}=t_{t}=20 n s\).
2. TIMING MEASUREMMENT REFERENCE LEVEL IS \(\frac{V_{11}+V_{1 L}}{2}\)

AD7547 ORDERING GUIDE \({ }^{1}\)
\begin{tabular}{|c|c|c|c|c|}
\hline Model \({ }^{2}\) & Temperature Range & \begin{tabular}{l}
Relative \\
Accuracy
\end{tabular} & Gain Error & Package Option \({ }^{3}\) \\
\hline AD7547JN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\pm 6 \mathrm{LSB}\) & N-24 \\
\hline AD7547KN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2\) LSB & \(\pm 3 \mathrm{LSB}\) & N-24 \\
\hline AD7547LN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2\) LSB & \(\pm 1\) LSB & N-24 \\
\hline AD7547JP & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\pm 6 \mathrm{LSB}\) & P-28A \\
\hline AD7547KP & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2\) LSB & \(\pm 3 \mathrm{LSB}\) & P-28A \\
\hline AD7547LP & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2\) LSB & \(\pm 1 \mathrm{LSB}\) & P-28A \\
\hline AD7547JR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\pm 6 \mathrm{LSB}\) & R-24 \\
\hline AD7547KR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\pm 3 \mathrm{LSB}\) & R-24 \\
\hline AD7547LR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2\) LSB & \(\pm 1\) LSB & R-24 \\
\hline AD7547AQ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\pm 6 \mathrm{LSB}\) & Q-24 \\
\hline AD7547BQ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\pm 3\) LSB & Q-24 \\
\hline AD7547CQ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\pm 1\) LSB & Q-24 \\
\hline AD7547SQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\pm 6 \mathrm{LSB}\) & Q-24 \\
\hline AD7547TQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\pm 3\) LSB & Q-24 \\
\hline AD7547UQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 / 2\) LSB & \(\pm 2\) LSB & Q-24 \\
\hline AD7547SE & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\pm 6 \mathrm{LSB}\) & E-28A \\
\hline AD7547TE & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\pm 3 \mathrm{LSB}\) & E-28A \\
\hline AD7547UE & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 / 2\) LSB & \(\pm 2\) LSB & E-28A \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Analog Devices reserves the right to ship ceramic packages (D-24A) in lieu of cerdip packages (Q-24).
\({ }^{2}\) To order MIL-STD-883, Class B processed parts, add /883B to part number. Contact your local sales office for military data sheets.
\({ }^{3} \mathrm{E}=\) Leadless Ceramic Chip Carrier; \(\mathbf{N}=\) Plastic DIP; \(\mathbf{P}=\) Plastic Leaded Chip Carrier; \(\mathbf{Q}=\) Cerdip; \(\mathbf{R}=\) SOIC. For outline information see Package Information section.

Figure 2. Timing Diagram for AD7547

\section*{AD7537 PIN CONFIGURATIONS}


\section*{PIN FUNCTION DESCRIPTION (DIP)}
\begin{tabular}{lll}
\hline PIN & MNEMONIC & DESCRIPTION \\
\hline 1 & AGNDA & Analog Ground for DAC A. \\
2 & \(\mathrm{I}_{\mathrm{OUTA}}\) & Current output terminal of DAC A. \\
3 & \(\mathrm{R}_{\text {FBA }}\) & Feedback resistor for DAC A. \\
4 & \(\mathrm{~V}_{\mathrm{REFA}}\) & Reference input to DAC A. \\
5 & CS & Chip Select Input. Active low. \\
\(6-14\) & \(\mathrm{DB} 0-\mathrm{DB} 7\) & Eight data inputs, DB0-DB7. \\
12 & DGND & Digital Ground. \\
15 & A0 & Address Line 0. \\
16 & Al & Address Line 1. \\
17 & \(\overline{\mathrm{CLR}}\) & Clear Input. Active low. Clears all registers. \\
18 & \(\overline{\mathrm{WR}}\) & Write Input. Active low. \\
19 & \(\overline{\text { UPD }}\) & Updates DAC Registers from inputs registers. \\
20 & \(\mathrm{~V}_{\mathrm{DD}}\) & Power supply input. Nominally +12V to +15 V , with \(\pm 10 \%\) tolerance. \\
21 & \(\mathrm{~V}_{\text {REFB }}\) & Reference input to DAC B. \\
22 & \(\mathrm{R}_{\text {FBB }}\) & Feedback resistor for DAC B. \\
23 & \(\mathrm{I}_{\mathrm{OUTB}}\) & Current output terminal of DAC B. \\
24 & AGNDB & Analog Ground for DAC B. \\
\hline
\end{tabular}

\section*{ABSOLUTE MAXIMUM RATINGS*}
( \(\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\) unless otherwise stated)
\begin{tabular}{|c|c|}
\hline \(V_{\text {DD }}\) to DGND & \(-0.3 \mathrm{~V},+17 \mathrm{~V}\) \\
\hline \(\mathrm{V}_{\text {REFA }}, \mathrm{V}_{\text {REFB }}\) to AGND, & \(\pm 25 \mathrm{~V}\) \\
\hline \(\mathrm{V}_{\text {RFBA }}, \mathrm{V}_{\text {RFBB }}\) to AGND, & \(\pm 25 \mathrm{~V}\) \\
\hline Digital Input Voltage to DGND & \(-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}\) \\
\hline I Outa, \(\mathrm{I}_{\text {Outb }}\) to DGND & \(-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}\) \\
\hline AGND to DGND & \(-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}\) \\
\hline Power Dissipation (Any Package) & \\
\hline To \(+75^{\circ} \mathrm{C}\) & 450 mW \\
\hline Derates above \(+75^{\circ} \mathrm{C}\) & . \(6 \mathrm{~mW} /{ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}


\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are removed.



PLCC


\section*{PIN FUNCTION DESCRIPTION (DIP)}
\begin{tabular}{|c|c|c|}
\hline PIN & MNEMONIC & DESCRIPTION \\
\hline 1 & AGND & Analog Ground. \\
\hline 2 & Iouta & Current output terminal of DACA. \\
\hline 3 & \(\mathrm{R}_{\text {FBA }}\) & Feedback resistor for DACA. \\
\hline 4 & V \({ }_{\text {REFA }}\) & Reference input to DACA. \\
\hline 5 & \(\overline{\text { CSA }}\) & Chip Select Input for DAC A. Active low. \\
\hline 6-18 & DB0-DB11 & 12 data inputs, DB0 (LSB)- DB11 (MSB). \\
\hline 12 & DGND & Digital Ground. \\
\hline 19 & \(\overline{\mathrm{WR}}\) & Write Input. Data transfer occurs on rising edge of WR. See Table I. \\
\hline 20 & \(\overline{\text { CSB }}\) & Chip Select Input for DACB. Active low. \\
\hline 21 & \(\mathrm{V}_{\text {DD }}\) & Power supply input. Nominally +12 V to +15 V with \(\pm 10 \%\) tolerance. \\
\hline 22 & \(\mathrm{V}_{\text {REFB }}\) & Reference input to DACB. \\
\hline 23 & \(\mathrm{R}_{\text {FBB }}\) & Feedback resistor of DACB. \\
\hline 24 & \(\mathrm{I}_{\text {OUTB }}\) & Current output terminal of DACB. \\
\hline
\end{tabular}

\section*{CIRCUIT INFORMATION}

\section*{D/A SECTION}

The AD7537/AD7547 contains two identical 12-bit multiplying D/A converters. Each DAC consists of a highly stable R-2R ladder and 12 N -channel current steering switches. Figure 3 shows a simplified D/A circuit for DAC A. In the R-2R ladder, binary weighted currents are steered between I IUTTA and AGND. The current flowing in each ladder leg is constant, irrespective of switch state. The feedback resistor \(R_{\text {FBA }}\) is used with an op-amp to convert the current flowing in I OUTA to a voltage output.


Figure 3. Simplified Circuit Diagram for DACA

\section*{EQUIVALENT CIRCUIT ANALYSIS}

Figure 4 shows the equivalent circuit for one of the D/A converters (DAC A) in the AD7537/AD7547. A similar equivalent circuit can be drawn for DACB. Note that AGND is common to both DAC A and DAC B.


Figure 4. Equivalent Analog Circuit for DACA
\(\mathrm{C}_{\text {OUt }}\) is the output capacitance due to the N -channel switches and varies from about 50 pF to 150 pF with digital input code. The current source \(\mathrm{I}_{\mathrm{LKG}}\) is composed of surface and junction leakages and approximately doubles every \(10^{\circ} \mathrm{C} . \mathrm{R}_{\mathrm{O}}\) is the equivalent output resistance of the device which varies with input code.

\section*{DIGITAL CIRCUIT INFORMATION}

The digital inputs are designed to be both TTL and 5V CMOS compatible. All logic inputs are static-protected MOS gates with typical input currents of less than \(\ln A\).

\section*{FEATURES}

\section*{All Grades 14-Bit Monotonic over the Full Temperature Range \\ Low Cost 14-Bit Upgrade for 12-Bit Systems 14-Bit Parallel Load with Double Buffered Inputs \\ Small 24-Pin, 0.3" DIP and SOIC \\ Low Output Leakage ( \(<\mathbf{2 0 n A}\) ) over the Full Temperature Range}

\section*{APPLICATIONS}

Microprocessor Based Control Systems
Digital Audio

\section*{Precision Servo Control}

Control and Measurement in High Temperature Environments

\section*{GENERAL DESCRIPTION}

The AD7538 is a 14 -bit monolithic CMOS D/A converter which uses laser trimmed thin-film resistors to achieve excellent linearity.
The DAC is loaded by a single 14-bit wide word using standard Chip Select and Memory Write Logic. Double buffering, which is optional using LDAC, allows simultaneous update in a system containing multiple AD7538s.

A novel low leakage configuration (U.S. Patent No. 4,590,456) enables the AD7538 to exhibit excellent output leakage current characteristics over the specified temperature range.

The AD7538 is manufactured using the Linear Compatible CMOS (LC \({ }^{2}\) MOS) process. It is speed compatible with most microprocessors and accepts TTL or CMOS logic level inputs.

FUNCTIONAL BLOCK DIAGRAM


\section*{PRODUCT HIGHLIGHTS}
1. Guaranteed Monotonicity

The AD7538 is guaranteed monotonic to 14 -bits over the full temperature range for all grades.
2. Low Cost

The AD7538, with its 14 -bit dynamic range, affords a low cost solution for 12-bit system upgrades.
3. Small Package Size

The AD7538 is packaged in a small 24-pin, 0.3" DIP and a 24-pin SOIC.
4. Low Output Leakage

By tying \(\mathrm{V}_{\text {ss }}\) (Pin 24) to a negative voltage, it is possible to achieve a low output leakage current at high temperatures.
5. Wide Power Supply Tolerance

The device operates on a +12 to \(+15 \mathrm{~V} \mathrm{~V}_{\mathrm{DD}}\), with a \(\pm 5 \%\) tolerance on this nominal figure. All specifications are guaranteed over this range.



\begin{tabular}{|c|c|c|c|c|}
\hline Parameter & \multicolumn{2}{|l|}{\(\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {min }}, \mathrm{T}_{\text {max }}\)} & Units & Test Conditions/Comments \\
\hline Output Current Setling Time & 1.5 & - & \(\mu \mathrm{Smax}\) & \begin{tabular}{l}
To 0.003\% of full-scale range. \\
\(I_{\text {Out }}\) load \(=100 \Omega\), \\
\(\mathrm{C}_{\mathrm{EXT}}=13 \mathrm{pF}\). DAC register alternately \\
loaded with all 1 s and all 0 s . \\
Typical value of Settling Time is \(0.8 \mu \mathrm{~s}\).
\end{tabular} \\
\hline Digital to Analog Glitch Impulse & 20 & - & nV-sectyp & \[
\begin{aligned}
& \text { Measured with } V_{\text {REF }}=0 \mathrm{~V} . \mathrm{I}_{\text {OUT }} \text { load } \\
& =100 \Omega, \mathrm{C}_{\text {EXT }}=13 \mathrm{pF} \text {. DAC } \\
& \text { register alternately loaded with all } \\
& \text { Is and all } 0 \mathrm{~s} \text {. }
\end{aligned}
\] \\
\hline Multiplying Feedthrough Error & 3 & 5 & mV p-ptyp & \(\mathrm{V}_{\mathrm{REF}}= \pm 10 \mathrm{~V}, 10 \mathrm{kHz}\) sine wave DAC register loaded with all 0s. \\
\hline Power Supply Rejection \(\Delta G\) ain \(/ \Delta V_{D D}\) & \(\pm 0.01\) & \(\pm 0.02\) & \% per \% max & \(\Delta \mathrm{V}_{\mathrm{DD}}= \pm 5 \%\) \\
\hline Output Capacitance & & & & \\
\hline Cout (Pin 3) & 260 & 260 & pF max & DAC register loaded with all 1 s \\
\hline Cout (Pin 3) & 130 & 130 & pF max & DAC register loaded with all 0 s \\
\hline Output Noise Voltage Density \((10 \mathrm{~Hz}-100 \mathrm{kHz})\) & 15 & - & \(\mathrm{nV} \sqrt{\mathrm{Hz}}\) typ & Measured between \(\mathrm{R}_{\text {FB }}\) and \(\mathrm{I}_{\text {OUT }}\) \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Temperature range as follows:
\begin{tabular}{ll} 
J, K Versions: & 0 to \(+70^{\circ} \mathrm{C}\) \\
A, B Versions: & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) \\
S, T Versions: & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
\end{tabular}
\({ }^{2}\) Specifications are guaranteed for a \(V_{D D}\) of +11.4 V to +15.75 V . At \(\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}\), the device is fully functional with degraded specifications.
\({ }^{3}\) Sample tested to ensure compliance.
Specifications subject to change without notice.

TIMING CHARACTERISTICS \({ }^{1}\)
\(N_{D 0}=+11.4 \mathrm{~V}\) to \(+15.75 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}}=+10 \mathrm{~V}, \mathrm{~V}_{\mathrm{PM3}}=\mathrm{V}_{\mathrm{PMM}}=\mathrm{OV}, \mathrm{V}_{\mathrm{SS}}=\mathrm{OV}\) or -30 OmV All specifications \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) unless otherwise stated. See Figure 1 for Timing Diagram.)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Parameter & Limit at
\[
\mathbf{T}_{\mathbf{A}}=25^{\circ} \mathrm{C}
\] & Limit at
\[
\begin{aligned}
& \mathrm{T}_{\mathrm{A}}=0 \text { to }+70^{\circ} \mathrm{C} \\
& \mathrm{~T}_{\mathrm{A}}=-25^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C}
\end{aligned}
\] & Limit at
\[
\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C} \text { to }+125^{\circ} \mathrm{C}
\] & Units & Test Conditions/Comments \\
\hline \(\mathrm{t}_{1}\) & 0 & 0 & 0 & ns min & \(\overline{\mathrm{CS}}\) to \(\overline{\mathrm{WR}}\) Setup Time \\
\hline \(\mathrm{t}_{2}\) & 0 & 0 & 0 & \(n s\) min & CS to WR Hold Time \\
\hline \(\mathrm{t}_{3}\) & 170 & 200 & 240 & ns min & LDAC Pulse Width \\
\hline \(t_{4}\) & 170 & 200 & 240 & ns min & Write Pulse Width \\
\hline \(t_{5}\) & 140 & 160 & 180 & ns min & Data Setup Time \\
\hline \(t_{6}\) & 20 & 20 & 30 & ns min & Data Hold Time \\
\hline
\end{tabular}

NOTES
\({ }^{1}\) Temperature range as follows:
J, K Versions:
A, B Versions:
S, T Versions:

0 to \(+70^{\circ} \mathrm{C}\)
\(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
\(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
Specifications subject to change without notice.

\section*{ABSOLUTE MAXIMUM RATINGS*}
( \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) unless otherwise stated)
\(V_{\text {DD }}\) (Pin 23) to DGND . . . . . . . . . . . . . \(-0.3 \mathrm{~V},+17 \mathrm{~V}\)
\(\mathrm{V}_{\text {SS }}(\operatorname{Pin} 24)\) to AGND . . . . . . . . . . . . . \(-15 \mathrm{~V},+0.3 \mathrm{~V}\)
V \(_{\text {REF }}\) (Pin 1) to AGND . . . . . . . . . . . . . . . . . \(\pm 25 \mathrm{~V}\)
\(\mathrm{V}_{\mathrm{RFB}}(\operatorname{Pin} 2)\) to AGND . . . . . . . . . . . . . . . . . \(\pm 25 \mathrm{~V}\)
Digital Input Voltage (Pins 6-22)
to DGND . . . . . . . . . . . . . . . \(-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
\(\mathrm{V}_{\mathrm{PIN} 3}\) to DGND . . . . . . . . . . . . . \(-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
AGND to DGND . . . . . . . . . . . . \(-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
Power Dissipation (Any Package)


Operating Temperature Range
Commercial (J, K versions) . . . . . . . . . . . 0 to \(+70^{\circ} \mathrm{C}\)
Industrial (A, B versions) . . . . . . . . . \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
Extended (S, T versions) . . . . . . . . . \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
Storage Temperature . . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Lead Temperature (Soldering, 10sec) . . . . . . . . . \(+300^{\circ} \mathrm{C}\)
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are inserted.

\section*{TERMINOLOGY}

\section*{RELATIVE ACCURACY}

Relative accuracy or end-point nonlinearity is a measure of the maximum deviation from a straight line passing through the end-points of the DAC transfer function. It is measured after adjusting for zero error and full-scale error and is normally expressed in Least Significant Bits or as a percentage of full-scale reading.

\section*{DIFFERENTIAL NONLINEARITY}

Differential nonlinearity is the difference between the measured change and the ideal 1LSB change between any two adjacent codes. A specified differential nonlinearity of \(\pm 1\) LSB max over the operating temperature range ensures monotonicity.

\section*{GAIN ERROR}

Gain error is a measure of the output error between an ideal DAC and the actual device output. It is measured with all 1 s in the DAC after offset error has been adjusted out and is expressed in Least Significant Bits. Gain error is adjustable to zero with an external potentiometer.

\section*{DIGITAL-TO-ANALOG GLITCH IMPULSE}

The amount of charge injected from the digital inputs to the analog output when the inputs change state is called Digital-to-Ana\(\log\) Glitch Impulse. This is normally specified as the area of the glitch in either pA-secs or nV -secs depending upon whether the glitch is measured as a current or voltage. It is measured with \(\mathrm{V}_{\mathrm{REF}}=\mathrm{AGND}\).

\section*{OUTPUT CAPACITANCE}

This is the capacitance from I OUt to AGND.

\section*{OUTPUT LEAKAGE CURRENT}

Output Leakage Current is current which appears at \(\mathrm{I}_{\text {OUT }}\) with the DAC register loaded to all 0s.

\section*{MULTIPLYING FEEDTHROUGH ERROR}

This is the ac error due to capacitive feedthrough from \(\mathrm{V}_{\mathrm{REF}}\) terminal to \(\mathrm{I}_{\text {OUT }}\) with DAC register loaded to all zeros.

\section*{ORDERING GUIDE}
\begin{tabular}{l|l|l|l|l}
\hline Model & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Relative \\
Accuracy
\end{tabular} & \begin{tabular}{l} 
Full-Scale \\
Error
\end{tabular} & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD7538JN & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & \(\pm 2 \mathrm{LSB}\) & \(\pm 8 \mathrm{LSB}\) & \(\mathrm{N}-24\) \\
AD7538KN & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\pm 4 \mathrm{LSB}\) & \(\mathrm{N}-24\) \\
AD7538JR & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & \(\pm 2 \mathrm{LSB}\) & \(\pm 8 \mathrm{LSB}\) & \(\mathrm{R}-24\) \\
AD7538KR & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\pm 4 \mathrm{LSB}\) & \(\mathrm{R}-24\) \\
AD7538AQ & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 2 \mathrm{LSB}\) & \(\pm 8 \mathrm{LSB}\) & \(\mathrm{Q}-24\) \\
AD7538BQ & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\pm 4 \mathrm{LSB}\) & \(\mathrm{Q}-24\) \\
AD7538SQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 2 \mathrm{LSB}\) & \(\pm 8 \mathrm{LSB}\) & \(\mathrm{Q}-24\) \\
AD7538TQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\pm 4 \mathrm{LSB}\) & \(\mathrm{Q}-24\) \\
\hline
\end{tabular}
\({ }^{\star} \mathbf{N}=\) Plastic DIP; \(\mathbf{Q}=\) Cerdip; \(\mathbf{R}=\) SOIC. For outline information see Package Information section.

\section*{PIN FUNCTION DESCRIPTION}
\begin{tabular}{cll} 
PIN & MNEMONIC & DESCRIPTION \\
1 & V \(_{\text {REF }}\) & Voltage Reference. \\
2 & R \(_{\text {FB }}\) & Feedback resistor. Used to close the loop around an external op amp. \\
3 & I \(_{\text {OUT }}\) & Current Output Terminal. \\
4 & AGND & Analog Ground \\
5 & DGND & Digital Ground \\
\(6-19\) & DB13-DB0 & Data Inputs. Bit 13(MSB) to Bit 0(LSB). \\
20 & LDAC & Chip Select input. Active LOW. \\
21 & \(\overline{\text { CS }}\) & Asynchronous Load DAC input. Active LOW. \\
22 & \(\overline{\text { WR }}\) & Write input. Active LOW.
\end{tabular}
\begin{tabular}{|llll|}
\hline\(\overline{\text { CS }}\) & \(\overline{\text { LDAC }}\) & \(\overline{\mathbf{W R}}\) & OPERATION \\
\hline 0 & 1 & 0 & Load Input Register. \\
1 & 0 & \(\mathbf{X}\) & Load DAC Register from Input Register. \\
0 & 0 & 0 & Input and DAC Registers are transparent \\
1 & 1 & \(\mathbf{X}\) & No operation. \\
\(\mathbf{X}\) & 1 & 1 & No operation. \\
\hline
\end{tabular}

NOTE: \(\mathbf{X}=\) Don't Care.
\(23 \quad V_{\text {DD }}\)
+12 V to +15 V supply input.
Bias pin for High Temperature Low Leakage configuration. To implement low leakage system, the pin should be at a negative voltage. See Figures 4 and 5 for recommended circuitry.

\section*{FEATURES}

Four 12-Bit DACs in One Package
4-Quadrant Multiplication
Separate References
Single Supply Operation
Guaranteed Specifications with +3.3 V/+5 V Supply Low Power
Versatile Serial Interface
Simultaneous Update Capability
Reset Function
28-Pin SOIC, SSOP and DIP Packages

\section*{APPLICATIONS}

\section*{Process Control}

Portable Instrumentation
General Purpose Test Equipment

\section*{GENERAL DESCRIPTION}

The AD7564 contains four 12 -bit DACs in one monolithic device. The DACs are standard current output with separate \(\mathrm{V}_{\mathrm{REF}}, \mathrm{I}_{\mathrm{OUT} 1}, \mathrm{I}_{\mathrm{OUT} 2}\) and \(\mathrm{R}_{\mathrm{FB}}\) terminals. These DACs operate from a single +5 V supply (Normal Mode) and a single +3.3 V to +5 V supply (Biased Mode).
The AD7564 is a serial input device. Data is loaded using \(\overline{\text { FSIN }}\), CLKIN and SDIN. Two address pins A0 and A1 set up a device address, and this feature may be used to simplify device loading in a multi-DAC environment. Alternatively, A0 and A1 can be ignored and the serial out capability used to configure a daisy-chained system.
All DACs can be simultaneously updated using the asynchronous \(\overline{\mathrm{LDAC}}\) input, and they can be cleared by asserting the asynchronous \(\overline{\text { CLR }}\) input.
The device is packaged in 28-pin SOIC, SSOP and DIP packages.

\section*{FUNCTIONAL BLOCK DIAGRAM}


\section*{PRODUCT HIGHLIGHTS}
1. The AD7564 contains four 12-bit current output DACs with separate \(V_{\text {REF }}\) inputs.
2. The AD7564 can be operated from a single +5 V supply (Normal Mode) or a single +3.3 V to +5 V supply (Biased Mode).
3. Simultaneous update capability and reset function are available.
4. The AD7564 features a fast, versatile serial interface compatible with all modern microprocessors and microcomputers.

ORDERING GUIDE
\begin{tabular}{l|l|l|l|l}
\hline Model & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Linearity \\
Error (LSBs)
\end{tabular} & \begin{tabular}{l} 
Nominal \\
Supply Voltage
\end{tabular} & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD7564BN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 0.5\) & +5 V & \(\mathrm{~N}-28\) \\
AD7564BR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 0.5\) & +5 V & \(\mathrm{R}-28\) \\
AD7564BRS & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 0.5\) & +5 V & \(\mathrm{RS}-28\) \\
AD7564AR-B & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1\) & +3.3 V to +5 V & \(\mathrm{R}-28\) \\
AD7564ARS-B & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1\) & +3.3 V to +5 V & RS-28 \\
\hline
\end{tabular}
\({ }^{\star} \mathrm{N}=\) DIP; R = SOIC; RS = SSOP. For outline information see Package Information section.

\footnotetext{
This is a preliminary data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

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}

\section*{AD7564-SPECIFICATIONS}

Normal Mode
\(\left(V_{D D}=+4.75 \mathrm{~V}\right.\) to \(+5.25 \mathrm{~V} ; \mathrm{I}_{\text {OUT1 }} A\) to \(I_{\text {OUT1 }} D=I_{\text {OUT2 } 2} A=I_{\text {OUT } 2} B=A G N D=0 \mathrm{~V} ; \mathrm{V}_{\text {REF }}=+10 \mathrm{~V} ; \mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\), unless otherwise noted)
\begin{tabular}{|c|c|c|c|}
\hline Parameter & B Grade & Units & Test Conditions/Comments \\
\hline \multicolumn{4}{|l|}{ACCURACY} \\
\hline Resolution & 12 & Bits & \(1 \mathrm{LSB}=\mathrm{V}_{\mathrm{REF}} / 2^{12}=2.44 \mathrm{mV}\) when \(\mathrm{V}_{\mathrm{REF}}=10 \mathrm{~V}\) \\
\hline Relative Accuracy & \(\pm 0.5\) & LSB max & \\
\hline Differential Nonlinearity & \(\pm 0.9\) & LSB max & All Grades Guaranteed Monotonic Over Temperature \\
\hline \multicolumn{4}{|l|}{Gain Error} \\
\hline \(+25^{\circ} \mathrm{C}\) & \(\pm 4\) & LSBs max & \\
\hline \(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) & \(\pm 5\) & LSBs max & \\
\hline Gain Temperature Coefficient \({ }^{2}\) & 2 & ppm FSR \(/{ }^{\circ} \mathrm{C}\) typ & \\
\hline & 5 & ppm FSR \(/{ }^{\circ} \mathrm{C}\) max & \\
\hline \multicolumn{4}{|l|}{Output Leakage Current} \\
\hline \multicolumn{4}{|l|}{IOUT1} \\
\hline \(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) & 200 & \(n A\) max & \\
\hline \multicolumn{4}{|l|}{REFERENCE INPUT \({ }^{\text {a }}\)} \\
\hline Input Resistance & 12 & \(\mathrm{k} \Omega\) max & Typical Input Resistance \(=9 \mathrm{k} \Omega\) \\
\hline Ladder Resistance Mismatch & 2 & \% max & Typically \(0.6 \%\) \\
\hline \multicolumn{4}{|l|}{DIGITAL INPUTS} \\
\hline \(V_{\text {INH }}\), Input High Voltage & 2.4 & V min & + \({ }^{2}\) \\
\hline \(V_{\text {INL }}\), Input Low Voltage & 0.8 & \(V\) max & - \(\mathrm{S}^{\text {a }}\) \\
\hline \(\mathrm{I}_{\text {INH }}\), Input Current & \(\pm 1\) & \(\mu \mathrm{A}\) max & 人 \()^{3}\) \\
\hline \(\mathrm{C}_{\text {IN }}\), Input Capacitance \({ }^{2}\) & 10 & pF max & - a \(^{\text {a }}\) \\
\hline \multicolumn{4}{|l|}{DIGITAL OUTPUT (SDOUT)} \\
\hline Output Low Voltage ( \(\mathrm{V}_{\mathrm{OL}}\) ) & 0.4 & \(V\) max & - \\
\hline Output High Voltage ( \(\mathrm{V}_{\mathrm{OH}}\) ) & 4.0 & V min & - \\
\hline \multicolumn{4}{|l|}{POWER REQUIREMENTS} \\
\hline \(V_{\text {DD }}\) Range & 4.75/5.25 & \(V \min / V_{\text {max }}\) & \\
\hline \multicolumn{4}{|l|}{Power Supply Rejection} \\
\hline \multirow[t]{2}{*}{\(\mathrm{I}_{\mathrm{DD}}\)} & 300 & \(\mu \mathrm{A}\) max & \(\mathrm{V}_{\text {INH }}=4.0 \mathrm{~V} \min , \mathrm{~V}_{\text {INL }}=0.4 \mathrm{~V}\) max \\
\hline & 2 & mA max & \(\mathrm{V}_{\text {INH }}=2.4 \mathrm{~V}\) min, \(\mathrm{V}_{\text {INL }}=0.8 \mathrm{~V}\) max \\
\hline
\end{tabular}

NOTES
\({ }^{1}\) Temperature range is as follows: B Version: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\).
\({ }^{2}\) Not production tested. Guaranteed by characterization at initial product release.
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> Biased Mode \({ }^{1}\)
> \(\left(V_{\text {DD }}=+3 \mathrm{~V}\right.\) to \(+5.5 \mathrm{~V} ; \mathrm{V}_{\text {IOUT1 }}=\mathrm{V}_{\text {IOUT2 } 2}=A G N D=1.23 \mathrm{~V} ; \mathrm{V}_{\text {REF }}=0 \mathrm{~V}\) to \(2.45 \mathrm{~V} ; \mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MXX }}\), unless otherwise noted)
\begin{tabular}{|c|c|c|c|}
\hline Parameter & A Grade \({ }^{2}\) & Units & Test Conditions/Comments \\
\hline \multicolumn{4}{|l|}{ACCURACY} \\
\hline Resolution & 12 & Bits & \[
\begin{aligned}
& 1 \mathrm{LSB}=\left(\mathrm{V}_{\text {IOUT2 } 2}-\mathrm{V}_{\text {REE }}\right) / 2^{12}=300 \mu \mathrm{~V} \text { when } \\
& \mathrm{V}_{\text {Iout } 2}=1.23 \mathrm{~V} \text { and } \mathrm{V}_{\text {REF }}=0 \mathrm{~V}
\end{aligned}
\] \\
\hline Relative Accuracy & \(\pm 1\) & LSB max & \\
\hline Differential Nonlinearity & \(\pm 0.9\) & LSB max & All Grades Guaranteed Monotonic Over Temperature \\
\hline \multicolumn{4}{|l|}{Gain Error} \\
\hline \(+25^{\circ} \mathrm{C}\) & \(\pm 4\) & LSBs max & \\
\hline \(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) & \(\pm 5\) & LSBs max & \\
\hline Gain Temperature Coefficient \({ }^{3}\) & 2 & ppm FSR \(/{ }^{\circ} \mathrm{C}\) typ & \\
\hline \multicolumn{3}{|l|}{\multirow[t]{2}{*}{}} & \multirow[t]{2}{*}{See Terminology Section} \\
\hline & & \[
\mathrm{I}_{\text {out }}
\] & \\
\hline @ \(+25^{\circ} \mathrm{C}\) & 10 & \(n A\) max & \\
\hline \(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) & 200 & \(n A\) max & \\
\hline @ \(\mathrm{I}_{\mathrm{OUT} 2}\) Pins & & \(\mathrm{k} \Omega\) min & This Varies with DAC Input Code \\
\hline \multicolumn{3}{|l|}{DIGITAL INPUTS} & \multirow[t]{2}{*}{} \\
\hline \(\mathrm{V}_{\text {INH }}\), Input High Voltage \(@ \mathrm{~V}_{\mathrm{DD}}=+5 \mathrm{~V}\) & 2.4 & V min \(\mathrm{V}^{2}\) & \\
\hline \(\mathrm{V}_{\text {INH }}\), Input High Voltage \(@ \mathrm{~V}_{\text {DD }}=+3.3 \mathrm{~V}\) & 2.1 & V min \(\mathrm{S}^{\text {a }}\), & \multirow[t]{2}{*}{} \\
\hline \(\mathrm{V}_{\text {INL }}\), Input Low Voltage @ \(\mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V}\) & 0.8 & \(\mathrm{V}_{\text {max }} \mathrm{V}\) max & \\
\hline \(\mathrm{V}_{\text {INL }}\), Input Low Voltage @ \(\mathrm{V}_{\mathrm{DD}}=+3.3 \mathrm{~V}\) & 0.6 & \(V \mathrm{max}^{\text {max }}\) & \\
\hline \(\mathrm{I}_{\mathrm{INH}}\), Input Current & \[
\frac{ \pm 1}{10}
\] & HA max pF max & \\
\hline \multicolumn{4}{|l|}{DIGITAL OUTPUT (SDOUT)} \\
\hline Output Low Voltage ( \(\mathrm{V}_{\text {OL }}\) ) & 0.4 < & \(V_{\text {max }}{ }^{-1}\) & \(\mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V}\) \\
\hline Output Low Voltage ( \(\mathrm{V}_{\text {OL }}\) ) & 0.2 & \(\checkmark\) max & \(\mathrm{V}_{\mathrm{DD}}=+3.3 \mathrm{~V}\) \\
\hline Output High Voltage ( \(\mathrm{V}_{\mathrm{OH}}\) ) & 4.0 & \(\checkmark V_{\text {min }}\) & \(\mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V}\) \\
\hline Output High Voltage ( \(\mathrm{V}_{\mathrm{OH}}\) ) & \(\mathrm{V}_{\mathrm{DD}}-0.2\) & \(\checkmark\) min & \(\mathrm{V}_{\mathrm{DD}}=+3.3 \mathrm{~V}\) \\
\hline \multicolumn{4}{|l|}{POWER REQUIREMENTS} \\
\hline \(V_{D D}\) Range & 4.75/5.25 & V min/V max & \\
\hline Power Supply Sensitivity \({ }^{2}\) \(\Delta\) Gain \(/ \Delta V_{D D}\) & -75 & dB typ & \\
\hline \multirow[t]{2}{*}{\(\mathrm{I}_{\mathrm{DD}}\)} & 300 & \(\mu \mathrm{A}\) max & \(\mathrm{V}_{\text {INH }}=\mathrm{V}_{\mathrm{DD}}-0.1 \mathrm{~V}\) min, \(\mathrm{V}_{\text {INL }}=0.1 \mathrm{~V}\) max; \\
\hline & 2 & mA max & \begin{tabular}{l}
SDOUT Open Circuit \\
\(\mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{INH}}=2.4 \mathrm{Vmin}, \mathrm{V}_{\mathrm{INL}}=\) 0.8 V max; SDOUT Open Circuit
\end{tabular} \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) These specifications apply with the devices biased up at 1.23 V for single supply applications. The model numbering reflects this by means of a "-B" suffix (for example: AD7564AN-B). Figure 16 is an example of Biased Mode Operation.
\({ }^{2}\) Temperature ranges is as follows: A Version: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\).
\({ }^{3}\) Not production tested. Guaranteed by characterization at initial product release.
Specifications subject to change without notice.

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\section*{AC Performance Characteristics}
\(\left(V_{D D}=+4.75 \mathrm{~V}\right.\) to \(+5.25 \mathrm{~V} ; \mathrm{V}_{\text {IOUT1 }}=\mathrm{V}_{\text {10ut2 }}=\mathrm{AGND}=0 \mathrm{~V} . \mathrm{V}_{\text {REF }}=6 \mathrm{~V}\) rms, 1 kHz sine wave; DAC output op amp is Normal Mode AD843; \(\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MII }}\) to \(\mathrm{T}_{\text {max }}\), unless otherwise noted. These characteristics are included for Design Guidance and are not subject to test.)
\begin{tabular}{|c|c|c|c|}
\hline Parameter & B Grade & Units & Test Conditions/Comments \\
\hline DYNAMIC PERFORMANCE Output Voltage Settling Time & 500 & ns typ & To \(0.01 \%\) of Full-Scale Range. DAC Latch Alternately Loaded with All 0 s and All 1s \\
\hline Digital-to-Analog Glitch Impulse & 40 & nV -s typ & Measured with \(\mathrm{V}_{\mathrm{REF}}=0 \mathrm{~V}\). DAC Register Alternately Loaded with All 0 s and All 1s \\
\hline Multiplying Feedthrough Error & -70 & dB max & \(\mathrm{V}_{\text {REF }}=20 \mathrm{~V} \mathrm{p}-\mathrm{p}, 10 \mathrm{kHz}\) Sine Wave. DAC Latch Loaded with All 0s \\
\hline Channel-to-Channel Isolation & -76 & dB typ & Feedthrough from Any One Reference to the Others with 20 V p-p, 10 kHz Sine Wave Applied \\
\hline Digital Crosstalk & 10 & nV-s typ & Effect of All Os to All 1s Code Transition on Nonselected DACs \\
\hline Digital Feedthrough & 10 & nV-s typ & Feedthrough to Any DAC Output with FSIN High and Square Wave Applied to SDIN and SCLK \\
\hline Total Harmonic Distortion & -83 & dB typ & \(\mathrm{V}_{\text {ReF }}=6 \mathrm{~V} \mathrm{rms}, 1 \mathrm{kHz}\) Sine Wave \\
\hline \begin{tabular}{l}
Output Noise Spectral Density \\
@ 1 kHz
\end{tabular} & 20 & \(\mathrm{nV} / \sqrt{\mathrm{Hz}}\) & All 1s Loaded to the DAC. \(V_{\text {REF }}=0 \mathrm{~V}\). Output Op Amp Is ADOP07 \\
\hline
\end{tabular}

\section*{AC Performance Characteristics}
\(\left(V_{D D}=+3 \mathrm{~V}\right.\) to \(+5.5 \mathrm{~V} ; \mathrm{V}_{\text {IOUT1 }}=\mathrm{V}_{\text {toutr }}=\mathrm{AGND}=1.23 \mathrm{~V} . \mathrm{V}_{\text {RE }}=1 \mathrm{kHz}, 2.45 \mathrm{~V} \mathrm{p}-\mathrm{p}\), sine wave biased at 1.23 V ; DAC output op amp is AD820; \(\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {mIN }}\) to \(\mathrm{I}_{\text {max }}\), unless otherwise noted. These characteristics are included for Design GuidBiased Mode ance and are not subject to test.)
\begin{tabular}{|c|c|c|c|}
\hline Parameter & A Grade & Units & Test Conditions/Comments \\
\hline \multicolumn{4}{|l|}{DYNAMIC PERFORMANCE} \\
\hline Output Voltage Settling Time & 5 & \(\mu \mathrm{styp}\) & To \(0.01 \%\) of Full Scale Range. \(\mathrm{V}_{\text {Ref }}=0 \mathrm{~V}\). DAC Latch Alternately Loaded with all 0 s and all 1 s . \\
\hline Digital to Analog Glitch Impulse & 40 & nV-s typ & Measured with \(\mathrm{V}_{\text {IOUT } 2}=0 \mathrm{~V}\) and \(\mathrm{V}_{\text {REF }}=0 \mathrm{~V}\). DAC Register Alternately Loaded with all 0 s and all 1 s . \\
\hline Multiplying Feedthrough Error & -70 & dB max & DAC Latch Loaded with all 0 s . \\
\hline \multirow[t]{2}{*}{Output Capacitance} & 60 & pF max & All 1s Loaded to DAC \\
\hline & 30 & pF max & All 0s Loaded to DAC \\
\hline Digital Feedthrough & 10 & nV-s typ & Feedthrough to Any DAC Output with FSIN HIGH and a Square Wave Applied to SDIN and CLKIN \\
\hline Total Harmonic Distortion & -83 & dB typ & \\
\hline Output Noise Spectral Density @ 1 kHz & 20 & \(\mathrm{nV} / \sqrt{\mathrm{Hz}}\) typ & All 1s Loaded to DAC. \(\mathrm{V}_{\text {IOuT2 }}=0 \mathrm{~V} ; \mathrm{V}_{\text {REF }}=0 \mathrm{~V}\) \\
\hline
\end{tabular}

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\title{
Timing Specifications \({ }^{1}\)
}
\begin{tabular}{l|l|l|l|l}
\hline Parameter & \begin{tabular}{l} 
Limit at \\
\(\mathbf{V}_{\mathbf{D D}}=+\mathbf{3} \mathbf{V}\) to +3.6 V V
\end{tabular} & \begin{tabular}{l} 
Limit at \\
\(\mathbf{V}_{\mathbf{D D}}=\mathbf{+ 4 . 7 5} \mathbf{V}\) to +5.25 V
\end{tabular} & Units & Description \\
\hline \(\mathbf{t}_{1}\) & 140 & 100 & ns min & CLKIN Cycle Time \\
\(\mathbf{t}_{2}\) & 60 & 40 & ns min & CLKIN High Time \\
\(\mathbf{t}_{3}\) & 60 & 40 & ns min & CLKIN Low Time \\
\(\mathbf{t}_{4}\) & 50 & 30 & ns min & FSIN Setup Time \\
\(\mathbf{t}_{5}\) & 50 & 30 & ns min & Data Setup Time \\
\(\mathbf{t}_{6}\) & 10 & 5 & ns min & Data Hold Time \\
\(\mathbf{t}_{7}\) & 125 & 90 & ns min & FSIN Hold Time \\
\(\mathbf{t}_{8}{ }^{2}\) & 100 & 70 & ns max & SDOUT Valid After CLKIN Falling Edge \\
\(t_{9}\) & 60 & 40 & LDAC, CLR Pulse Width \\
\hline
\end{tabular}

NOTES
\({ }^{1}\) Not production tested. Guaranteed by characterization at initial product release. All input signals are specified with \(\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}\left(10 \%\right.\) to \(90 \%\) of \(\left.\mathrm{V}_{\mathrm{DD}}\right)\) and timed from a voltage level of 1.6 V for a \(\mathrm{V}_{\mathrm{DD}}\) of 5 V and from a voltage level 1.35 V for a \(\mathrm{V}_{\mathrm{DD}}\) of 3.3 V .
\({ }^{2} \mathrm{t}_{8}\) is measured with the load circuit of Figure 2 and defined as the time required for the output to cross 0.8 V or 2.4 V with a \(\mathrm{V}_{\mathrm{DD}}\) of 5 V and 0.6 V or 2.1 V for a \(\mathrm{V}_{\mathrm{DD}}\) of 3.3 V .


Figure 1. Timing Diagram


Figure 2. Load Circuit for Digital Output Timing Specifications

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\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD7564 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

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\begin{tabular}{|c|c|c|}
\hline \begin{tabular}{l}
Pin \\
Number
\end{tabular} & Mnemonic & Description \\
\hline 1 & DGND & Digital Ground. \\
\hline 2 & \(\mathrm{I}_{\text {Out } 2} \mathrm{C}\) & \(\mathrm{I}_{\text {OUT2 }}\) terminal for DAC C. This should normally connect to the signal ground of the system. \\
\hline 3 & \(V_{\text {DD }}\) & Positive power supply. This is \(+5 \mathrm{~V} \pm 5 \%\). \\
\hline 4 & \(\mathrm{I}_{\text {OuT1 }} \mathrm{C}\) & \(\mathrm{I}_{\text {OUT1 }}\) terminal for DAC C. \\
\hline 5 & \(\mathrm{R}_{\mathrm{FB}} \mathrm{C}\) & Feedback resistor for DAC C. \\
\hline 6 & \(\mathrm{V}_{\text {REF }} \mathrm{C}\) & DAC C reference input. \\
\hline 7 & \(\mathrm{I}_{\text {OUT } 2} \mathrm{D}\) & \(\mathrm{I}_{\text {OUT2 }}\) terminal for DAC D. This should normally connect to the signal ground of the system. \\
\hline 8 & \(\mathrm{I}_{\text {Out1 }} \mathrm{D}\) & \(\mathrm{I}_{\text {OUT1 }}\) terminal for DAC D. \\
\hline 9 & \(\mathrm{R}_{\mathrm{FB}} \mathrm{D}\) & Feedback resistor for DAC D. \\
\hline 10 & \(\mathrm{V}_{\text {REF }} \mathrm{D}\) & DAC D reference input. \\
\hline 11 & SDOUT & This shift register output allows multiple devices to be connected in a daisy chain configuration. \\
\hline 12 & \(\overline{\text { CLR }}\) & Asynchronous \(\overline{C L R}\) input. When this input is taken low, all DAC latches are loaded with all 0 s. \\
\hline 13 & \(\overline{\text { LDAC }}\) & Asynchronous LDAC input. When this input is taken low, all DAC latches are simultaneously updated with the contents of the input latches. \\
\hline 14 & \(\overline{\text { FSIN }}\) & Level-triggered control input (active low). This is the frame synchronization signal for the input data. When \(\overline{\mathrm{FSIN}}\) goes low, it enables the input shift register, and data is transferred on the falling edges of CLKIN. If the address bits are valid, the 12 -bit DAC data is transferred to the appropriate input latch on the sixteenth falling edge after \(\overline{\text { FSIN }}\) goes low. \\
\hline 15 & SDIN & Serial data input. The device accepts a 16-bit word. DB0 and DB1 are DAC select bits. DB2 and DB3 are device address bits. DB4 to DB15 contain the 12-bit data to be loaded to the selected DAC. \\
\hline 16 & CLKIN & Clock Input. Data is clocked into the input shift register on the falling edges of CLKIN. \\
\hline 17 & A1 & Device address pin. This input in association with A0 gives the device an address. If DB2 and DB3 of the serial input stream do not correspond to this address, the data which follows is ignored and not loaded to any input latch. However, it will appear at SDOUT irrespective of this. \\
\hline 18 & A0 & Device address pin. This input in association with Al gives the device an address. \\
\hline 19 & \(\mathrm{V}_{\text {ReF }} \mathrm{A}\) & DAC A reference input. \\
\hline 20 & \(\mathrm{R}_{\mathrm{FB}} \mathrm{A}\) & Feedback resistor for DAC A. \\
\hline 21 & \(\mathrm{I}_{\text {OUT } 1} \mathrm{~A}\) & \(\mathrm{I}_{\text {OUT1 }}\) terminal for DAC A. \\
\hline 22 & \(\mathrm{I}_{\text {OUT } 2} \mathrm{~A}\) & I \({ }_{\text {OUT2 }}\) terminal for DAC A. This should normally connect to the signal ground of the system. \\
\hline 23 & \(\mathrm{V}_{\text {REF }} \mathrm{B}\) & DAC B reference input. \\
\hline 24 & \(\mathrm{R}_{\mathrm{FB}} \mathrm{B}\) & Feedback resistor for DAC B. \\
\hline 25 & \(\mathrm{I}_{\text {OUT } 1} \mathrm{~B}\) & \(\mathrm{I}_{\text {OUT1 }}\) terminal for DAC B. \\
\hline 26 & N/C & No Connect pin. \\
\hline 27 & AGND & This pin connects to the back gates of the current steering switches. It should be connected to the signal ground of the system. \\
\hline 28 & \(\mathrm{I}_{\text {OUT2 }} \mathrm{B}\) & I \({ }_{\text {OUT2 }}\) terminal for DAC B. This should normally connect to the signal ground of the system. \\
\hline
\end{tabular}

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\section*{AD7564}

\section*{TERMINOLOGY}

\section*{Relative Accuracy}

Relative accuracy or endpoint linearity is a measure of the maximum deviation from a straight line passing through the endpoints of the DAC transfer function. It is measured after adjusting for zero error and full-scale error and is normally expressed in Least Significant Bits or as a percentage of full-scale reading.

\section*{Differential Nonlinearity}

Differential nonlinearity is the difference between the measured change and the ideal 1 LSB change between any two adjacent codes. A specified differential nonlinearity of 1 LSB maximum ensures monotonicity.

\section*{Gain Error}

Gain error is a measure of the output error between an ideal DAC and the actual device output. It is measured with all 1 s in the DAC after offset error has been adjusted out and is expressed in Least Significant Bits. Gain error is adjustable to zero with an external potentiometer.

\section*{Output Leakage Current}

Output leakage current is current which flows in the DAC ladder switches when these are turned off. For the I IOUT1 terminal, it can be measured by loading all 0 s to the DAC and be measured by loading all 0 s to the DAC and measuring the \(\mathrm{I}_{\mathrm{OUT1}}\) current. Minimum current will flow in the \(\mathrm{I}_{\mathrm{OUT} 2}\) line when the DAC is loaded with all 1 s . This is a combination of the switch leakage current and the ladder termination resistor current. The \(\mathrm{I}_{\text {OUT2 } 2}\) leakage current is typically equal to that in \(\mathrm{I}_{\text {OUT1. }}\)

\section*{Output Capacitance}

This is the capacitance from the \(\mathrm{I}_{\text {OUT1 }}\) pin to AGND.

\section*{Output Voltage Settling Time}

This is the amount of time it takes for the output to settle to a specified level for a full-scale input change. For the AD7564, it is specified with the AD843 as the output op amp.

\section*{Digital to Analog Glitch Impulse}

This is the amount of charge injected into the analog output when the inputs change state. It is normally specified as the area of the glitch in either pA-secs or nV -secs, depending upon whether the glitch is measured as a current or voltage signal. It is measured with the reference input connected to AGND and the digital inputs toggled between all 1 s and all 0 s .

\section*{AC Feedthrough Error}

This is the error due to capacitive feedthrough from the DAC reference input to the DAC \(I_{\text {OUT }}\) terminal, when all 0 s are loaded in the DAC.

\section*{Channel-to-Channel Isolation}

Channel-to-channel isolation refers to the proportion of input signal from one DAC's reference input which appears at the output of any other DAC in the device and is expressed in dBs .

\section*{Digital Crosstalk}

The glitch impulse transferred to the output of one converter due to a change in digital input code to the other converter is defined as the Digital Crosstalk and is specified in nV -secs.
Digital Feedthrough
When the device is not selected, high frequency logic activity on the device digital inputs is capacitively coupled through the device to show up at on the \(\mathrm{I}_{\text {OUT }}\) pin and subsequently on the op amp output. This noise is digital feedthrough.

Table I. AD7564 Loading Sequence
\begin{tabular}{llllllllllll|ll|lll} 
DB15 & & & & & & & DB0 \\
\hline DB11 & DB10 & DB9 & DB8 & DB7 & DB6 & DB5 & DB4 & DB3 & DB2 & DB1 & DB0 & A1 & A0 & DS1 & DS0 \\
\hline
\end{tabular}

Table II. DAC Selection
\begin{tabular}{l|l|l}
\hline DS1 & DS0 & Function \\
\hline 0 & 0 & DAC A Selected \\
0 & 1 & DAC B Selected \\
1 & 0 & DAC C Selected \\
1 & 1 & DAC D Selected \\
\hline
\end{tabular}

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\section*{FEATURES}

Eight 12-Bit DACs in One Package
4-Quadrant Multiplication
Separate References
Single +5 V Supply
Low Power: 1 mW
Versatile Serial Interface
Simultaneous Update Capability
Reset Function
44-Pin PQFP and PLCC
APPLICATIONS
Process Control
Automatic Test Equipment
General Purpose Instrumentation

\section*{GENERAL DESCRIPTION}

The AD7568 contains eight 12 -bit DACs in one monolithic device. The DACs are standard current output with separate \(\mathrm{V}_{\mathrm{REF}}, \mathrm{I}_{\mathrm{OUT} 1}, \mathrm{I}_{\mathrm{OUT} 2}\) and \(\mathrm{R}_{\mathrm{FB}}\) terminals.
The AD7568 is a serial input device. Data is loaded using \(\overline{\text { FSIN }}\), CLKIN and SDIN. One address pin, A0, sets up a device address, and this feature may be used to simplify device loading in a multi-DAC environment.
All DACs can be simultaneously updated using the asynchronous \(\overline{\text { LDAC }}\) input and they can be cleared by asserting the asynchronous \(\overline{\mathrm{CLR}}\) input.
The AD7568 is housed in a space-saving 44 -pin plastic quad

\section*{FUNCTIONAL BLOCK DIAGRAM}
 flatpack and 44-lead PLCC.


PIN CONFIGURATIONS

Plastic Leaded Chip Carrier


\footnotetext{
This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.
}

\begin{tabular}{|c|c|c|c|}
\hline Parameter & AD7568B \({ }^{2}\) & Units & Test Conditions/Comments \\
\hline \begin{tabular}{l}
ACCURACY \\
Resolution \\
Relative Accuracy \\
Differential Nonlinearity \\
Gain Error \\
\(+25^{\circ} \mathrm{C}\) \\
\(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) \\
Gain Temperature Coefficient \\
Output Leakage Current \\
IOUT1 \\
@ \(+25^{\circ} \mathrm{C}\) \\
\(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\)
\end{tabular} & \[
\begin{aligned}
& 12 \\
& \pm 0.5 \\
& \pm 0.9 \\
& \pm 4 \\
& \pm 5 \\
& 2 \\
& 5 \\
& 10 \\
& 200
\end{aligned}
\] & \begin{tabular}{l}
Bits \\
LSB max \\
LSB max \\
LSBs max \\
LSBs max \\
ppm FSR \(/{ }^{\circ} \mathrm{C}\) typ \\
ppm FSR \(/{ }^{\circ} \mathrm{C}\) max \\
\(n A\) max \\
nA max
\end{tabular} & \begin{tabular}{l}
\(1 \mathrm{LSB}=\mathrm{V}_{\mathrm{REF}} / 2^{12}=1.22 \mathrm{mV}\) when \(\mathrm{V}_{\mathrm{REF}}=5 \mathrm{~V}\) \\
All Grades Guaranteed Monotonic over Temperature \\
See Terminology Section
\end{tabular} \\
\hline \begin{tabular}{l}
REFERENCE INPUT \\
Input Resistance Ladder Resistance Mismatch
\end{tabular} & \[
\begin{aligned}
& 5 \\
& 9 \\
& 2
\end{aligned}
\] & \begin{tabular}{l}
\(\mathrm{k} \Omega\) min \\
\(\mathrm{k} \Omega\) max \\
\% max
\end{tabular} & \begin{tabular}{l}
Typical Input Resistance \(=7 \mathrm{k} \Omega\) \\
Typically 0.6\%
\end{tabular} \\
\hline \begin{tabular}{l}
DIGITAL INPUTS \\
\(\mathrm{V}_{\text {INH }}\), Input High Voltage \\
\(\mathrm{V}_{\text {INL }}\), Input Low Voltage \\
\(\mathrm{I}_{\mathrm{INH}}\), Input Current \\
\(\mathrm{C}_{\text {IN }}\), Input Capacitance
\end{tabular} & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 1 \\
& 10
\end{aligned}
\] & \begin{tabular}{l}
V min \\
V max \\
\(\mu \mathrm{A}\) max \\
pF max
\end{tabular} & \\
\hline \begin{tabular}{l}
POWER REQUIREMENTS \\
\(V_{\text {DD }}\) Range \\
Power Supply Sensitivity \(\Delta\) Gain \(/ \Delta V_{D D}\) \(I_{D D}\)
\end{tabular} & \[
\begin{aligned}
& 4.75 / 5.25 \\
& -75 \\
& 300 \\
& 3.5 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
\(\mathrm{V} \min / V \max\) \\
dB typ \\
\(\mu \mathrm{A}\) max \\
mA max
\end{tabular} & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{INH}}=4.0 \mathrm{~V} \text { min, } \mathrm{V}_{\text {INL }}=0.4 \mathrm{~V} \text { max } \\
& \mathrm{V}_{\mathrm{INH}}=2.4 \mathrm{~V} \text { min, } \mathrm{V}_{\text {INL }}=0.8 \mathrm{~V} \text { max }
\end{aligned}
\] \\
\hline
\end{tabular}

\section*{AC PERFORMANCE CHARACTERISTICS \\ (These characteristics are included for Design Guidance and are not subject to test. DAC output op amp is AD843.)}
\begin{tabular}{|c|c|c|c|}
\hline Parameter & AD7568B \(^{\mathbf{2}}\) & Units & Test Conditions/Comments \\
\hline \multicolumn{4}{|l|}{DYNAMIC PERFORMANCE} \\
\hline Output Voltage Settling Time & 500 & ns typ & To 0.01\% of Full-Scale Range. DAC Latch Alternately Loaded with All 0 s and All 1s. \\
\hline Digital to Analog Glitch Impulse & 40 & nV-s typ & Measured with \(\mathrm{V}_{\text {REF }}=0 \mathrm{~V}\). DAC Register Alternately Loaded with All 0 s and All 1s. \\
\hline Multiplying Feedthrough Error & -66 & dB max & \(\mathrm{V}_{\mathrm{REF}}=20 \mathrm{~V}\) pk-pk, 10 kHz Sine Wave. DAC Latch Loaded with All Os. \\
\hline Output Capacitance & 60 & pF max & All is Loaded to DAC. \\
\hline & 30 & pF max & All 0s Loaded to DAC. \\
\hline Channel-to-Channel Isolation & -76 & dB typ & Feedthrough from Any One Reference to the Others with 20 V pk-pk, 10 kHz Sine Wave Applied. \\
\hline Digital Crosstalk & 40 & nV-s typ & Effect of all Os to all 1s Code Transition on Nonselected DACs. \\
\hline Digital Feedthrough & 40 & nV-s typ & Feedthrough to Any DAC Output with FSIN High and Square Wave Applied to SDIN and SCLK. \\
\hline Total Harmonic Distortion & -83 & dB typ & \(\mathrm{V}_{\text {REF }}=6 \mathrm{~V}\) rms, 1 kHz Sine Wave. \\
\hline \begin{tabular}{l}
Output Noise Spectral Density \\
@ 1 kHz
\end{tabular} & 20 & \(\mathrm{nV} / \sqrt{\mathrm{Hz}}\) & All 1s Loaded to the DAC. \(\mathrm{V}_{\text {REF }}=0 \mathrm{~V}\). Output Op Amp is AD OP-07. \\
\hline
\end{tabular}

\footnotetext{
NOTES
\({ }^{1}\) Temperature range as follows: B Version: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\).
\({ }^{2}\) All specifications also apply for \(\mathrm{V}_{\text {REF }}=+10 \mathrm{~V}\), except relative accuracy which degrades to \(\pm 1\) LSB.
Specifications subject to change without notice.
}

\begin{tabular}{|c|c|c|c|c|}
\hline Parameter & Limit at
\[
\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}
\] & Limit at
\[
\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C}
\] & Units & Description \\
\hline \(\mathrm{t}_{1}\) & 100 & 100 & ns min & CLKIN Cycle Time \\
\hline \(\mathrm{t}_{2}\) & 40 & 40 & ns min & CLKIN High Time \\
\hline \(\mathrm{t}_{3}\) & 40 & 40 & ns min & CLKIN Low Time \\
\hline \(\mathrm{t}_{4}\) & 30 & 30 & ns min & \(\overline{\text { FSIN }}\) Setup Time \\
\hline \(t_{5}\) & 30 & 30 & ns min & Data Setup Time \\
\hline \(t_{6}\) & 5 & 5 & ns min & Data Hold Time \\
\hline \(\mathrm{t}_{7}\) & 90 & 90 & ns min & \(\overline{\text { FSIN }}\) Hold Time \\
\hline \(\mathrm{t}_{8}{ }^{2}\) & 70 & 70 & ns max & SDOUT Valid After CLKIN Falling Edge \\
\hline \(\underline{t_{9}}\) & 40 & 40 & ns min & \(\overline{\text { LDAC, }} \overline{\text { CLR }}\) Pulse Width \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Sample tested at \(+25^{\circ} \mathrm{C}\) to ensure compliance. All input signals are specified with \(\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%\) to \(90 \%\) of 5 V\()\) and timed from a voltage level of 1.6 V . \({ }^{2} \mathrm{t}_{8}\) is measured with the load circuit of Figure 2 and defined as the time required for the output to cross 0.8 V or 2.4 V .


Figure 1. Timing Diagram


Figure 2. Load Circuit for Digital Output Timing Specifications

\section*{ORDERING GUIDE}
\begin{tabular}{l|l|l|l}
\hline Model & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Linearity \\
Error (LSBs)
\end{tabular} & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD7568BS & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 0.5\) & \(\mathrm{~S}-44\) \\
AD7568BP & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 0.5\) & \(\mathrm{P}-44 \mathrm{~A}\) \\
\hline
\end{tabular}
*S = Plastic Quad Flatpack (PQFP), P = Plastic Leaded Chip Carrier (PLCC). For outline information see Package Information section.

\section*{AD7568}

\section*{ABSOLUTE MAXIMUM RATINGS \({ }^{\mathbf{1}}\)}
( \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) unless otherwise noted)
\(\mathrm{V}_{\mathrm{DD}}\) to DGND . .................... -0.3 V to +6 V
\(\mathrm{I}_{\text {OUT1 }}\) to DGND . . . . . . . . . . . . . . -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
\(\mathrm{I}_{\mathrm{OUT} 2}\) to DGND . . . . . . . . . . . . . -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
Digital Input Voltage to DGND . . . -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
\(\mathrm{V}_{\mathrm{RFB}}, \mathrm{V}_{\mathrm{REF}}\) to DGND . . . . . . . . . . . . . . . . . . . . . . \(\pm 15 \mathrm{~V}\)
Input Current to Any Pin Except Supplies \({ }^{2}\). . . . . . . \(\pm 10 \mathrm{~mA}\)
Operating Temperature Range
Commercial Plastic (B Versions) . . . . . . . . . \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
Storage Temperature Range . . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Lead Temperature (Soldering, 10 secs) . . . . . . . . . . . \(+300^{\circ} \mathrm{C}\)
Power Dissipation (Any Package) to \(+75^{\circ} \mathrm{C}\). . . . . . . 250 mW
Derates above \(+75^{\circ} \mathrm{C}\) by . . . . . . . . . . . . . . . . . . \(10 \mathrm{~mW} /{ }^{\circ} \mathrm{C}\)
NOTES
\({ }^{1}\) Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
\({ }^{2}\) Transient currents of up to 100 mA will not cause SCR latch-up.

\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are removed.

Table I. AD7568 Loading Sequence

\section*{DB15}

DB0
\begin{tabular}{|l|l|l|l|l|l|l|l|l|l|l|l|l|l|l|l|}
\hline DB11 & DB10 & DB9 & DB8 & DB7 & DB6 & DB5 & DB4 & DB3 & DB2 & DB1 & DB0 & A0 & DS2 & DS1 & DS0 \\
\hline
\end{tabular}

Table II. DAC Selection
\begin{tabular}{l|l|l|l}
\hline DS2 & DS1 & DS0 & Function \\
\hline 0 & 0 & 0 & DAC A Selected \\
0 & 0 & 1 & DAC B Selected \\
0 & 1 & 0 & DAC C Selected \\
0 & 1 & 1 & DAC D Selected \\
1 & 0 & 0 & DAC E Selected \\
1 & 0 & 1 & DAC F Selected \\
1 & 1 & 0 & DAC G Selected \\
1 & 1 & 1 & DAC H Selected \\
\hline
\end{tabular}

\section*{TERMINOLOGY}

\section*{Relative Accuracy}

Relative Accuracy or endpoint linearity is a measure of the maximum deviation from a straight line passing through the endpoints of the DAC transfer function. It is measured after adjusting for zero error and full-scale error and is normally expressed in Least Significant Bits or as a percentage or full-scale reading.

\section*{Differential Nonlinearity}

Differential nonlinearity is the difference between the measured change and the ideal 1 LSB change between any two adjacent codes. A specified differential nonlinearity of 1 LSB maximum ensures monotonicity.

\section*{Gain Error}

Gain Error is a measure of the output error between an ideal DAC and the actual device output. It is measured with all 1 s in the DAC after offset error has been adjusted out and is expressed in Least Significant Bits. Gain error is adjustable to zero with an external potentiometer.

\section*{Output Leakage Current}

Output leakage current is current which flows in the DAC ladder switches when these are turned off. For the \(\mathrm{I}_{\text {OUT } 1}\) terminal, it can be measured by loading all 0 s to the DAC and measuring the \(\mathrm{I}_{\mathrm{OUT} 1}\) current. Minimum current will flow in the \(\mathrm{I}_{\mathrm{OUT} 2}\) line when the DAC is loaded with all 1s. This is a combination of the switch leakage current and the ladder termination resistor current. The \(\mathrm{I}_{\mathrm{OUT} 2}\) leakage current is typically equal to that in \(\mathrm{I}_{\mathrm{OUT} 1}\).

\section*{Output Capacitance}

This is the capacitance from the \(\mathrm{I}_{\text {OUT1 }}\) pin to AGND.

\section*{Output Voltage Settling Time}

This is the amount of time it takes for the output to settle to a specified level for a full-scale input change. For the AD7568, it is specified with the AD843 as the output op amp.

\section*{Digital to Analog Glitch Impulse}

This is the amount of charge injected into the analog output when the inputs change state. It is normally specified as the area of the glitch in either pA-secs or nV -secs, depending upon whether the glitch is measured as a current or voltage signal. It is measured with the reference input connected to AGND and the digital inputs toggled between all 1 s and all 0 s .

\section*{AC Feedthrough Error}

This is the error due to capacitive feedthrough from the DAC reference input to the DAC \(\mathrm{I}_{\text {OUt }}\) terminal, when all 0 s are loaded in the DAC.

\section*{Channel-to-Channel Isolation}

Channel-to-channel isolation refers to the proportion of input signal from one DAC's reference input which appears at the output of any other DAC in the device and is expressed in dBs.

\section*{Digital Crosstalk}

The glitch impulse transferred to the output of one converter due to a change in digital input code to the other converter is defined as the Digital Crosstalk and is specified in nV-secs.

\section*{Digital Feedthrough}

When the device is not selected, high frequency logic activity on the device digital inputs is capacitively coupled through the device to show up as noise on the \(\mathrm{I}_{\mathrm{OUT}}\) pin and subsequently on the op amp output. This noise is digital feedthrough.


Figure 3. Supply Current vs. Logic Input Voltage


Figure 6. Integral Nonlinearity Error vs. \(V_{\text {REF }}\)


Figure 9. Digital-to-Analog Glitch Impulse


Figure 4. Supply Current vs. Temperature


Figure 7. Typical DAC to DAC Linearity Matching


Figure 10. Channel-to-Channel Isolation (1 DAC to 1 DAC)


Figure 5. Differential Nonlinearity Error vs. \(V_{\text {REF }}\)


Figure 8. Total Harmonic Distortion vs. Frequency


Figure 11. Channel-to-Channel Isolation (1 DAC to All Other DACs)

\section*{FEATURES}

On-Chip Latches for Both DACs
+12 V to +15 V Operation
DACs Matched to 1\%
Four Quadrant Multiplication
TTLCMOS Compatible from +12 V to +15 V
Latch Free (Protection Schottkys not Required)

\section*{APPLICATIONS}

Disk Drives
Programmable Filters
X-Y Graphics
Gain/Attenuation

\section*{GENERAL DESCRIPTION}

The AD7628 is a monolithic dual 8-bit digital/analog converter featuring excellent DAC-to-DAC matching. It is available in small \(0.3^{\prime \prime}\)-wide 20-pin DIPs and in 20-terminal surface mount packages.
Separate on-chip latches are provided for each DAC to allow easy microprocessor interface.
Data is transferred into either of the two DAC data latches via a common 8 -bit TTL/CMOS compatible input port. Control input \(\overline{\text { DAC A }} / D A C\) B determines which DAC is to be loaded. The AD7628's load cycle is similar to the write cycle of a random access memory, and the device is bus compatible with most 8 bit microprocessors, including 6502, 6809, 8085, Z 80 .
The device operates from a +12 V to +15 V power supply and is TTL-compatible over this range. Power dissipation is a low 20 mW .
Both DACs offer excellent four quadrant multiplication characteristics with a separate reference input and feedback resistor for each DAC.

FUNCTIONAL BLOCK DIAGRAM


\section*{PRODUCT HIGHLIGHTS}
1. DAC to DAC matching: since both of the AD7628 DACs are fabricated at the same time on the same chip, precise matching and tracking between DAC A and DAC B is inherent. The AD7628's matched CMOS DACs make a whole new range of applications circuits possible, particularly in the audio, graphics and process control areas.
2. Small package size: combining the inputs to the on-chip DAC latches into a common data bus and adding a \(\overline{\mathrm{DACA}}\) DAC B select line has allowed the AD7628 to be packaged in a small 20 -pin \(0.3^{\prime \prime}\) wide DIP, 20-pin SOIC, 20-terminal PLCC and 20-terminal LCC.
3. TTL-Compatibility: All digital inputs are TTL-compatible over \(a+12 \mathrm{~V}\) to +15 V power supply range.

\title{
 \\ \(N_{\text {REF }} A=V_{\text {REF }} B=+10 V\); OUT \(A=\) OUT \(B=O V\) unless othenvise specified)
}


\section*{AC PERFORMANCE CHARACTERISTICS}

These characteristics are included for Design Guidance only and are not subject to test
\(V_{D 0}=+10.8 V\) to \(+15.75 V\). (Measured Using Recommended P.C. Board Layout (Figure 7) and AD644 as Output Amplifiers)
\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline Parameter & \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}^{1}\) & \[
\begin{aligned}
& \mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C} \\
& \text { to }+85^{\circ} \mathrm{C}^{1}
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C} \text { to } \\
& +125^{\circ} \mathrm{C}^{1}
\end{aligned}
\] & Units & Test Conditions/Comments & & \\
\hline DCSUPPLY REJECTION ( \(\Delta \mathrm{GAIN} / \Delta \mathrm{V}_{\mathrm{DD}}\) ) & 0.01 & 0.02 & 0.02 & \% per \% max & \(\Delta \mathrm{V}_{\text {DD }}= \pm 5 \%\) & * & \\
\hline CURRENTSETTLING TIME & 350 & 400 & 400 & ns max & \[
\begin{aligned}
& \text { To } 1 / 2 \mathrm{LSB} . \text { Out A/Out B load }=100 \Omega . \\
& \mathrm{WR}=\mathrm{CS}=0 \mathrm{~V} . \\
& \mathrm{DB} 0-\mathrm{DB} 7=0 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{DD}} \text { or } \mathrm{V}_{\mathrm{DD}} \text { to } 0 \mathrm{~V} \\
& \hline
\end{aligned}
\] & & \\
\hline DIGITAL-TO-ANALOG GLITCH IMPULSE & 330 & - & - & nV sectyp & For Code Transition 00000000 to 11111111 & & \\
\hline ```
OUTPUTCAPACITANCE
    Cout \(A\)
    Cout \(B\)
    Cout A
    Cout \({ }^{B}\)
``` & \[
\begin{aligned}
& 25 \\
& 25 \\
& 60 \\
& 60 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 25 \\
& 25 \\
& 60 \\
& 60 \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& 25 \\
& 25 \\
& 60 \\
& 60 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
pF max \\
pF max \\
pF max \\
pF max \(^{x}\)
\end{tabular} & \begin{tabular}{l}
DAC Latches Loaded with 00000000 \\
DACLatches Loaded with 11111111
\end{tabular} & & \\
\hline \[
\begin{aligned}
& \text { ACFEEDTHROUGH } \\
& \text { V REF A to OUT A } \\
& \text { V REF }^{\text {B to OUT B }} \\
& \hline
\end{aligned}
\] & \[
\begin{array}{r}
-70 \\
-70 \\
\hline
\end{array}
\] & \[
\begin{aligned}
& -65 \\
& -65
\end{aligned}
\] & \[
\begin{array}{r}
-65 \\
-65 \\
\hline
\end{array}
\] & \[
\begin{aligned}
& \mathrm{dB} \text { max } \\
& \mathrm{dB} \text { max }
\end{aligned}
\] & \(\mathrm{V}_{\text {REF }} A, \mathrm{~V}_{\text {REF }} B=20 \mathrm{~V}\) p-p Sine Wave @ 10 kHz & & \\
\hline ```
CHANNEL-TO-CHANNELISOLA
    V \(_{\text {REF }} A\) to OUT B
    \(V_{\text {REF }}\) B to OUT A
``` & \begin{tabular}{l}
\[
-80
\] \\
\(-80\)
\end{tabular} & - & - & dB typ dB typ & \begin{tabular}{l}
Both DAC Latches Loeded with 11111111. \\
\(\mathbf{V}_{\text {REF }} A=20 \mathrm{~V}\) p-p Sine Wave @ \(\mathbf{1 0 k H z}\) \\
\(V_{\text {REF }} B=0 V\) see Figure 6. \\
\(\mathbf{V}_{\text {REF }} B=20 \mathrm{~V}\) p-pSine \(\mathbf{W}\) ave @ 10 kHz \\
\(V_{\text {REF }} A=0 V\) see Figure 6.
\end{tabular} & & \\
\hline DIGITALCROSSTALK & 60 & - & - & \(\mathbf{n V}\) sectyp & Measured for Code Transition 00000000 to11111111 & & \\
\hline HARMONICDISTORTION & -85 & - & - & dB typ & \(\mathrm{V}_{\mathbf{N}}=\mathbf{6} \mathrm{V}\) rms @ \(\mathbf{1 k H z}\) & & \\
\hline
\end{tabular}

NOTES
\({ }^{\prime}\) Temperature Ranges are K Version; \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) B Version; \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
T Version; \(;-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
\({ }^{2}\) Specification applies to both DACs in AD7628.
\({ }^{3}\) Guaranteed by design but not production tested.
\({ }^{4}\) Logic inputs are MOS Gates. Typical input current \(\left(+25^{\circ} \mathrm{C}\right)\) is less than \(\ln A\).
Specifications subject to change without notice.

\section*{ABSOLUTE MAXIMUM RATINGS}
( \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) unless otherwise noted)
\begin{tabular}{|c|c|}
\hline \multicolumn{2}{|l|}{\multirow{15}{*}{do to DGND}} \\
\hline & \\
\hline & \\
\hline & \\
\hline & \\
\hline & \\
\hline & \\
\hline & \\
\hline & \\
\hline & \\
\hline & \\
\hline & \\
\hline & \\
\hline & \\
\hline & \\
\hline
\end{tabular}

\section*{CAUTION:}
1. ESD sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subjected to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts.
2. Do not insert this device into powered sockets. Remove power before insertion or removal.

ORDERING GUIDE
\begin{tabular}{l|l|l|l|l}
\hline Model \(^{1}\) & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Relative \\
Accuracy
\end{tabular} & \begin{tabular}{l} 
Gain \\
Error
\end{tabular} & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD7628KN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\pm 2 \mathrm{LSB}\) & \(\mathrm{N}-20\) \\
AD7628KP & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\pm 2 \mathrm{LSB}\) & P-20A \\
AD7628KR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\pm 2 \mathrm{LSB}\) & R-20 \\
AD7628BQ & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\pm 2 \mathrm{LSB}\) & \(\mathrm{Q}-20\) \\
AD7628TQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\pm 2 \mathrm{LSB}\) & \(\mathrm{Q}-20\) \\
AD7628TE & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\pm 2 \mathrm{LSB}\) & \(\mathrm{E}-20 \mathrm{~A}\) \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) To order MIL-STD-883, Class B process parts, add /883B to part number. Contact your local sales office for military data sheet.
\({ }^{2}\) For outline information see Package Information section.

\section*{TERMINOLOGY}

\section*{Relative Accuracy:}

Relative accuracy or endpoint nonlinearity is a measure of the maximum deviation from a straight line passing through the endpoints of the DAC transfer function. It is measured after adjusting for zero and full-scale and is normally expressed in LSBs or as a percentage of full-scale reading.

\section*{Differential Nonlinearity:}

Differential nonlinearity is the difference between the measured change and the ideal 1LSB change between any two adjacent
the operating temperature range ensures monotonicity.

\section*{Gain Error:}

Gain error is a measure of the output error between an ideal DAC and the actual device output. It is measured with all 1 s in the DAC latches after offset error has been adjusted out. Gain error of both DACs is adjustable to zero with external resistance.

\section*{Output Capacitance:}

Capacitance from OUT A or OUT B to AGND.

\section*{Digital-to-Analog Glitch Impulse:}

The amount of charge injected from the digital inputs to the analog output when the inputs change state. This is normally specified as the area of the glitch in either pA-secs or nV -secs depending upon whether the glitch is measured as a current or voltage signal. Glitch impulse is measured with \(\mathrm{V}_{\text {REF }} \mathrm{A}, \mathrm{V}_{\text {REF }} \mathrm{B}\) \(=\) AGND.

\section*{Channel-to-Channel Isolation:}

The proportion of input signal from one DAC's reference input which appears at the output of the other DAC, expressed as a ratio in dB .
Digital Crosstalk:
The glitch energy transferred to the output of one converter due to a change in digital input code to the other converter. Specified in nV secs.

\section*{PIN CONFIGURATIONS}



AD7628

\section*{INTERFACE LOGIC INFORMATION}

\section*{DAC Selection:}

Both DAC latches share a common 8-bit input port. The control input \(\overline{\mathrm{DAC}} \mathrm{A} / D A C\) B selects which DAC can accept data from the input port.

\section*{Mode Selection:}

Inputs \(\overline{\mathrm{CS}}\) and \(\overline{\mathrm{WR}}\) control the operating mode of the selected DAC. See Mode Selection Table below.

\section*{Write Mode:}

When \(\overline{\mathrm{CS}}\) and \(\overline{\mathrm{WR}}\) are both low the selected DAC is in the write mode. The input data latches of the selected DAC are transparent and its analog output responds to activity on DB0DB7.

\section*{Hold Mode:}

The selected DAC latch retains the data which was present on DB0-DB7 just prior to \(\overline{\mathrm{CS}}\) or \(\overline{\mathrm{WR}}\) assuming a high state. Both analog outputs remain at the values corresponding to the data in their respective latches.
\begin{tabular}{|c|c|c|c|c|}
\hline \(\overline{\text { DACA/ }}\) DACB & \(\overline{\mathrm{CS}}\) & \(\overline{\text { WR }}\) & DACA & DAC B \\
\hline L & L & L & WRITE & HOLD \\
\hline H & L & L & HOLD & WRITE \\
\hline X & H & X & HOLD & HOLD \\
\hline X & X & H & HOLD & HOLD \\
\hline
\end{tabular}

L = Low State H = High State X = Don't Care Mode Selection Table

\section*{WRITE CYCLE TIMING DIAGRAM}


\section*{CIRCUIT INFORMATION - D/A SECTION}

The AD7628 contains two identical 8-bit multiplying D/A converters, DAC A and DAC B. Each DAC consists of a highly stable thin film R-2R ladder and eight N-channel current steering switches. A simplified D/A circuit for DAC A is shown in Figure 1. An inverted R-2R ladder structure is used, that is, binary weighted currents are switched between the DAC output and AGND thus maintaining fixed currents in each ladder leg independent of switch state.


Figure 1. Simplified Functional Circuit for DAC A

\section*{EQUIVALENT CIRCUIT ANALYSIS}

Figure 2 shows an approximate equivalent circuit for one of the AD7628's D/A converters, in this case DAC A. A similar equivalent circuit can be drawn for DAC B. Note that AGND (Pin 1) is common for both DAC A and DAC B.

The current source I leakage is composed of surface and junction leakages and, as with most semiconductor devices, approximately doubles every \(10^{\circ} \mathrm{C}\). The resistor \(\mathrm{R}_{\mathrm{o}}\) as shown in Figure 2 is the equivalent output resistance of the device which varies with input code (excluding all 0 's code) from 0.8 R to \(2 R\). R is typically \(11 \mathrm{k} \Omega\). Cout is the capacitance due to the N -channel switches and varies from about 50 pF to 120 pF depending upon the digital input. \(g\left(V_{\text {REF }} A, N\right)\) is the Thevenin equivalent voltage generator due to the reference input voltage \(\mathrm{V}_{\text {REF }} \mathrm{A}\) and the transfer function of the R-2R ladder.

For further information on CMOS multiplying D/A converters refer to "CMOS DAC Application Guide, \(2^{\text {ND }}\) Edition" available from Analog Devices, Publication Number G872a-15-4/86.


Figure 2. Equivalent Analog Output Circuit of DAC A

\section*{CIRCUIT INFORMATION - DIGITAL SECTION}

The input buffers are simple CMOS level-shifters designed such that when the AD7628 is operated with \(\mathrm{V}_{\mathrm{DD}}\) from 10.8 V to 15.75 V , the buffer converts TTL input levels ( 2.4 V and 0.8 V ) into CMOS logic levels. When \(V_{I N}\) is in the region of 1.0 volt to 2.0 volts the input buffers operate in their linear region and pass a quiescent current, see Figure 3. To minimize power supply currents it is recommended that the digital input voltages be as close to the supply rails ( \(V_{\mathrm{DD}}\) and DGND) as is practically possible.
The AD7628 may be operated with any supply voltage in the range \(10.8 \leq \mathrm{V}_{\mathrm{DD}} \leq 15.75\) volts.


Figure 3. Typical Plot of Supply Current, IDD vs. Logic Input Voltage \(V_{I N}\) for \(V_{D D}=+15 V\).

FEATURES
Four/Eight 10-Bit DACs in One Package
Serial and Parallel Loading Facilities Available
AD7808-S Octal 10-Bit Serial Loading
AD7808-P Octal 10-Bit Parallel Loading
AD7804-S Quad 10-Bit Serial Loading
AD7804-P Quad 10-Bit Parallel Loading
3.3 V and 5 V Operation

Low Power All CMOS Construction
10 -Bit Resolution, \(\pm 1\) LSB DNL, \(\pm 1\) LSB INL
Four/Eight Output Amplifiers
Double Buffered DAC Registers
Power-Down Mode
Low Cost
APPLICATIONS
Optical Disk Drives
Automatic Test Equipment
Instrumentation Systems
Communication Systems
Process Control
Voltage Set Point Control
Trim Potentiometer Replacement
Automatic Calibration

\section*{GENERAL DESCRIPTION}

The AD7804/AD7808 are quad and octal 10-bit digital-toanalog converters, with serial or parallel data load facilities depending on the version used. These parts operate from a +5 V or \(+3.3 \mathrm{~V}( \pm 10 \%)\) power supply and incorporate an on-board reference. These DACs provide output signals in the form of \(\mathrm{V}_{\text {BIAS }} \pm \mathrm{V}_{\text {SWING }}\) that swing rail to rail.
On-chip control registers include a system control register and a channel control register. The system control register has control over all DACs in the package. Its controls include power down, input coding select, clearing of all DACs and the facility to put all DACs into standby. The channel control register, allows individual control over all DACs and its contents allow individual DACs to be cleared, put into standby and reference selection for the relevant DAC. The complete transfer function of each individual DAC can be shifted around the \(\mathrm{V}_{\text {BIAS }}\) point using an onchip 8-bit Sub DAC. All DACs contain double buffered data inputs, which allow all analog outputs to be simultaneously updated using the asynchronous \(\overline{\mathrm{LDAC}}\) input.

FUNCTIONAL BLOCK DIAGRAMS


\section*{PRODUCT HIGHLIGHTS}
1. The AD7804/AD7808 are complete voltage output 10-bit quad and octal DACs capable of operating from 5 V and 3.3 V supplies with on-board reference.
2. CMOS construction ensures very low power dissipation, the part dissipating \(5 \mathrm{~mW} / \mathrm{DAC}\) typically in normal operation.
3. The AD7804-S and AD7808-S have a fast versatile serial interface while the AD7804-P and AD7808-P offer a fast parallel interface. Both interfaces are compatible with all modern microprocessors and microcomputers, and the output voltage settles to \(\pm 1 / 2\) LSB within \(4 \mu\).

\footnotetext{
This is a preliminary data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.
}

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

\begin{tabular}{|c|c|c|c|c|}
\hline Parameter & \(3.3 \mathrm{~V} \pm 10 \%\) Version & \(5 \mathrm{~V} \pm 10 \%\) Version & Units & Comments \\
\hline \begin{tabular}{l}
STATIC PERFORMANCE \\
Main DAC \\
Resolution \\
Relative Accuracy \\
Differential Nonlinearity \\
Bias Offset Error \\
Plus or Minus Full-Scale Error \\
Minimum Load Resistance \\
Sub DAC \\
Resolution \\
Differential Nonlinearity
\end{tabular} & \[
\begin{aligned}
& 10 \\
& \pm 2 \\
& \pm 1 \\
& 25 \\
& 25 \\
& 2 \\
& \\
& 8 \\
& \pm 1
\end{aligned}
\] & \[
\begin{aligned}
& 10 \\
& \pm 2 \\
& \pm 1 \\
& 25 \\
& 25 \\
& 2 \\
& \\
& 8 \\
& \pm 1
\end{aligned}
\] & \begin{tabular}{l}
Bits \\
LSB max \\
LSB max \\
mV max \\
\(m V\) max \\
\(\mathrm{k} \Omega\) min \\
Bits \\
LSB
\end{tabular} & \begin{tabular}{l}
Guaranteed Monotonic DAC Code \(=0.5\) Full Scale \\
Guaranteed Monotonic
\end{tabular} \\
\hline \begin{tabular}{l}
OUTPUT CHARACTERISTICS \\
Output Voltage Range \\
Voltage Output Settling Time to 10 Bits \\
Settling Time to 8 Bits \\
Slew Rate \\
Digital-to-Analog Glitch Impulse \\
Digital Feedthrough \\
DC Output Impedance \\
Source/Sink Current \({ }^{1}\) \\
@ \(\mathrm{V}_{\mathrm{OUT}}=\mathrm{V}_{\mathrm{MIN}}\) \\
@ \(\mathrm{V}_{\mathrm{OUT}}=\mathrm{V}_{\mathrm{MAX}}\)
\end{tabular} & \(0 / \mathrm{V}_{\mathrm{DD}}\)
4
1
2
20
1
0.2
1
2 & \[
\begin{aligned}
& 0 / \mathrm{V}_{\mathrm{DD}} \\
& 4 \\
& 1 \\
& 2 \\
& 20 \\
& 1 \\
& 0.2 \\
& \\
& 1 \\
& 2 \\
& \hline
\end{aligned}
\] & V min/max \(\mu \mathrm{s}\) max \(\mu \mathrm{s}\) max \(\mathrm{V} / \mathrm{\mu} \mathrm{~s} \min\) nV-s typ nV-s typ \(\Omega\) typ mA max mA max & Typically \(2 \mu \mathrm{~s}\) \\
\hline \begin{tabular}{l}
DAC REFERENCE INPUTS \\
\(V_{\text {bias }}\) Range \\
\(\mathrm{V}_{\text {BIAS }}\) Input Impedance
\end{tabular} & \[
\begin{aligned}
& 1.15 / \mathrm{V}_{\mathrm{DD}} / 2 \\
& 500
\end{aligned}
\] & \[
\begin{aligned}
& 1.15 / \mathrm{VBD}^{2} 2 \\
& 500
\end{aligned}
\] & \(V \min / \max\) \(\mathrm{k} \Omega\) typ & \\
\hline \begin{tabular}{l}
DIGITAL INPUTS \\
Input High Voltage, \(\mathrm{V}_{\mathrm{IH}}\) Input Low Voltage, \(\mathrm{V}_{\mathrm{IL}}\) Input Leakage Current Input Capacitance Input Coding
\end{tabular} & \[
\begin{array}{|l|}
\hline 2.1 \\
0.6 \\
\pm 10 \\
8 \\
\text { 2s Complement/Binary } \\
\hline
\end{array}
\] & \begin{tabular}{l}
2.4
\[
0.8
\]
\[
\pm 10
\] \\
8 \\
2s Complement/Binary
\end{tabular} & \begin{tabular}{l}
V min \\
V max \\
\(\mu \mathrm{A}\) max \\
pF max
\end{tabular} & \\
\hline \begin{tabular}{l}
REFERENCE OUTPUT \\
REF OUT Output Voltage REF OUT Error @ \(+25^{\circ} \mathrm{C}\) \(\mathrm{T}_{\mathrm{MIN}}-\mathrm{T}_{\mathrm{MAX}}\) REF OUT Temperature Coefficient
\end{tabular} & \[
\begin{aligned}
& 1.26 \\
& \pm 5 \\
& \pm 7 \\
& 300
\end{aligned}
\] & \[
\begin{aligned}
& 1.26 \\
& \pm 5 \\
& \pm 7 \\
& 300
\end{aligned}
\] & \begin{tabular}{l}
V nom \\
\% max \\
\% max \\
\(\mathrm{ppm} /{ }^{\circ} \mathrm{C}\)
\end{tabular} & \\
\hline \begin{tabular}{l}
POWER REQUIREMENTS \\
\(V_{D D}\) \\
\(\mathrm{I}_{\mathrm{DD}}\) \\
@ \(+25^{\circ} \mathrm{C}\) \\
\(\mathrm{T}_{\mathrm{MIN}}-\mathrm{T}_{\mathrm{MAX}}\) \\
Power Dissipation \\
Normal Mode @ \(+25^{\circ} \mathrm{C}\) \\
\(\mathrm{T}_{\mathrm{MIN}^{-}}-\mathrm{T}_{\mathrm{MAX}}\) \\
Power Save Mode @ \(+25^{\circ} \mathrm{C}\) \\
\(\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}\)
\end{tabular} & \[
\begin{aligned}
& 3.3 \pm 10 \% \\
& 2 \\
& 2.5 \\
& 7.2+\mathrm{V}_{\mathrm{O}}{ }^{2} / \mathrm{R}_{\mathrm{L}} \\
& 9+\mathrm{V}_{\mathrm{O}}^{2} / \mathrm{R}_{\mathrm{L}} \\
& 1.5 \\
& 2
\end{aligned}
\] & \[
\begin{aligned}
& 5 \pm 10 \% \\
& 2.5 \\
& 3 \\
& \\
& 13.75+\mathrm{V}_{\mathrm{O}}^{2} / \mathrm{R}_{\mathrm{L}} \\
& 16.5+\mathrm{V}_{\mathrm{O}}^{2} / \mathrm{R}_{\mathrm{L}} \\
& 2 \\
& 3
\end{aligned}
\] & \begin{tabular}{l}
v \\
mA/DAC max mA/DAC max \\
mW/DAC max mW/DAC max \(\mu \mathrm{W} / \mathrm{DAC}\) max \(\mu\) W/DAC max
\end{tabular} & Excluding Load Currents \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1} \mathrm{~V}_{\text {MIN }}=\mathrm{V}_{\text {BIAS }} / 16, \mathrm{~V}_{\text {MAX }}=2 \mathrm{~V}_{\text {BIAS }}-\mathrm{V}_{\text {BIAS }} / 16\).
Specifications subject to change without notice.

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TIMING CHARACTERIST|CS \({ }^{1} \begin{aligned} & \left(V_{D D}=3.3 \mathrm{~V} \text { or } 5 \mathrm{~V} \pm 10 \% \text {; AGND }=\mathrm{DGND}=0 \mathrm{~V} \text {; } \mathrm{V}_{\text {BIAS }}=\text { REF OUT. All specifications } \mathrm{T}_{\text {mIN }} \text { to } \mathrm{T}_{\text {max }}\right.\end{aligned}\)
AD7804-S AND AD7808-S
\begin{tabular}{l|l|l|l|l}
\hline Parameter & \begin{tabular}{l} 
Limit at \\
\(\mathbf{T}_{\mathbf{A}}=\mathbf{+ 2 5} \mathbf{C}\)
\end{tabular} & \begin{tabular}{l} 
Limit at \(\mathbf{T}_{\mathbf{A}}=\) \\
\(\mathbf{- 4 0 ^ { \circ }} \mathbf{C} \mathbf{t o} \mathbf{+ 8 5}{ }^{\circ} \mathbf{C}\)
\end{tabular} & Units & Description \\
\hline \(\mathrm{t}_{1}\) & 100 & 100 & ns min & CLKIN Cycle Time \\
\(\mathrm{t}_{2}\) & 40 & 40 & ns min & CLKIN High Time \\
\(\mathrm{t}_{3}\) & 40 & 40 & ns min & CLKIN Low Time \\
\(\mathrm{t}_{4}\) & 30 & 30 & ns min & FSIN Setup Time \\
\(\mathrm{t}_{5}\) & 30 & 30 & ns min & Data Setup Time \\
\(\mathrm{t}_{6}\) & 5 & 5 & ns min & Data Hold Time \\
\(\mathrm{t}_{7}\) & 90 & 90 & ns min & \(\overline{\text { FSIN Hold Time }}\) \\
\(\mathrm{t}_{8}\) & 40 & 40 & ns min & LDAC, \(\overline{\text { CLR Pulse Width }}\) \\
\hline
\end{tabular}

NOTE
\({ }^{\prime}\) Guaranteed by design not production tested. All input signals are specified with \(\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}\left(10 \%\right.\) to \(90 \%\) of \(\left.\mathrm{V}_{\mathrm{DD}}\right)\) and timed from a voltage of 1.6 V .


Figure 1. Timing Diagram for AD7804-S and AD7808-S

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.
\begin{tabular}{|c|c|c|c|c|}
\hline Parameter & Limit at
\[
\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}
\] & \[
\begin{aligned}
& \text { Limit at } \mathrm{T}_{\mathrm{A}}= \\
& -40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C}
\end{aligned}
\] & Units & Description \\
\hline \(\mathrm{t}_{1}\) & 4 & 4 & ns min & Mode Valid to Address Setup Time \\
\hline \(\mathrm{t}_{2}\) & 0 & 0 & ns min & Mode Valid to Address Hold Time \\
\hline \(\mathrm{t}_{3}\) & 4 & 4 & \(n \mathrm{nmin}\). & Address Valid to Write Setup Time \\
\hline \(\mathrm{t}_{4}\) & 0 & 0 & ns min & Address Valid to Write Hold Time \\
\hline \(\mathrm{t}_{5}\) & 25 & 25 & ns min & Data Setup Time \\
\hline \(\mathrm{t}_{6}\) & 10 & 10 & ns min & Data Hold Time \\
\hline \(\mathrm{t}_{7}\) & 0 & 0 & ns min & Chip Select to Write Setup Time \\
\hline \(\mathrm{t}_{8}\) & 0 & 0 & ns min & Chip Select to Write Hold Time \\
\hline \(\mathrm{t}_{9}\) & 40 & 40 & ns min & Write Pulse Width \\
\hline \(\mathrm{t}_{10}\) & 0 & 0 & ns min & HBEN to Write Setup Time \\
\hline \(\mathrm{t}_{11}\) & 0 & 0 & ns min & HBEN to Write Hold Time \\
\hline \(\mathrm{t}_{12}\) & 40 & 40 & ns min & \(\overline{\text { LDAC }}\), \(\overline{\text { CLR }}\) Pulse Width \\
\hline
\end{tabular}

NOTE
\({ }^{1}\) Guaranteed by design not production tested. All input signals are specified with \(\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}\left(10 \%\right.\) to \(90 \%\) of \(\left.\mathrm{V}_{\mathrm{DD}}\right)\) and timed from a voltage of 1.6 V .


Figure 2. Timing Diagram for AD7804-P and AD7808-P Parallel Write

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.
\begin{tabular}{|c|c|}
\hline Mnemonic & Description \\
\hline \(\mathrm{AV}_{\text {DD }}\) & Analog Power Supply. +5 V or +3 V . \\
\hline \(D V_{D D}\) & Digital Power Supply. \\
\hline AGND & Ground reference point for analog circuitry. \\
\hline DGND & Ground reference point for digital circuitry. \\
\hline \(\mathrm{V}_{\text {BIAS }}\) & This is an external reference input for the DAC. When this reference is selected for the DAC in the control register, the analog output from the selected DAC swings around this point. \\
\hline REFOUT & Reference Output; this is a bandgap reference and is typically 1.26 V . \\
\hline CLKIN & Clock Input. Data is clocked into the input shift register on the falling edges of CLKIN. \\
\hline \(\overline{\text { FSIN }}\) & Level-triggered control input (active low). This is the frame synchronization signal for the input data. When \(\overline{\mathrm{FSIN}}\) goes low, it enables the input shift register and data is transferred on the falling edges of CLKIN. \\
\hline SDIN & Serial Data Input. These devices accept a 16-bit word. The first 2 bits (DB15 and DB14) are used to select either writing to the DACs data registers or to the control registers. If the DAC data register is selected, DB13 is used to select either the Main DAC or the Sub DAC, DB12 to DB10 provide the DAC address and DB9 to DB0 contain the 10 -bit data. If control registers are selected by the 2 MSBs , then remaining bits are defined in the section Serial Interface. \\
\hline \(\overline{\text { LDAC }}\) & Asynchronous \(\overline{\text { LDAC }}\) Input. When this digital input is taken low, all DAC registers are simultaneously updated with the contents of the DAC data registers. \\
\hline \(\overline{\text { CLR }}\) & Asynchronous \(\overline{C L R}\) Input. When this input is taken low, all DAC register outputs are cleared. \\
\hline \(\overline{\text { COMP }}\) & Compensation Pin. This is a compensation pin for the internal \(\mathrm{V}_{\mathrm{DD}} / 2\) reference and should be decoupled with a \(0.1 \mu \mathrm{~F}\) capacitor to analog ground. \\
\hline \(\mathrm{V}_{\text {OUTA }}-\mathrm{V}_{\text {OUTD }}\) & Analog output voltages from the DACs. \% \\
\hline \(\underline{\mathrm{V}_{\text {OUTE }}-\mathrm{V}_{\text {OUTH }}}\) & Analog output voltages from the DACs. \\
\hline
\end{tabular}

\section*{ABSOLUTE MAXIMUM RATINGS \({ }^{1}\)}
( \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) unless otherwise noted)
DV \({ }_{\text {DD }}\) to DGND . ............................ . -0.3 V to +7 V

AGND to DGND . . . . . . . . . . . . . . . . . . . . . . . \(-0.3 \mathrm{~V}+0.3 \mathrm{~V}\)
Digital Input Voltage to DGND . . . . -0.3 V to \(\mathrm{DV}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
Analog Input Voltage to AGND . . . . . -0.3 V to \(\mathrm{AV}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
REF OUT to AGND . . . . . . . . . . . . . . . . . . . . . -0.3 V to \(+\mathrm{V}_{\mathrm{DD}}\)
\(\mathrm{V}_{\text {BIAS }}\) to AGND ....................... -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
Input Current to Any Pin Except Supplies \({ }^{2}\).......... \(\pm 10 \mathrm{~mA}\)
Operating Temperature Range
Commercial Plastic (A, B Versions) ....... \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
Storage Temperature Range . . . . . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Junction Temperature . . . . . . . . . . . . . . . . . . . . . . . . . . \(+150^{\circ} \mathrm{C}\)

SOIC Package, Power Dissipation . . . . . . . . . . . . . . . 875 mW
\(\theta_{\mathrm{IA}}\) Thermal Impedance . . . . . . . . . . . . . . . . . . . . . . . . . \(75^{\circ} \mathrm{C} / \mathrm{W}\)
Lead Temperature, Soldering
Vapor Phase ( 60 sec ) . . . . . . . . . . . . . . . . . . . . . . . . \(+215^{\circ} \mathrm{C}\)
Infrared (15 sec) ................................... . \(+220^{\circ} \mathrm{C}\)
PQFP Package, Power Dissipation . . . . . . . . . . . . . . . . 500 mW
\(\theta_{\mathrm{JA}}\) Thermal Impedance . . . . . . . . . . . . . . . . . . . . . . . . \(95^{\circ} \mathrm{C} / \mathrm{W}\)
Lead Temperature, Soldering
Vapor Phase ( 60 sec ) . . . . . . . . . . . . . . . . . . . . . . . . \(+215^{\circ} \mathrm{C}\)
Infrared (15 sec) . . . . . . . . . . . . . . . . . . . . . . . . . . . . \(+220^{\circ} \mathrm{C}\)
NOTES
\({ }^{1}\) Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
\({ }^{2}\) Transient currents of up to 100 mA will not cause SCR latchup.

\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD7804/AD7808 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


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\begin{tabular}{|c|c|}
\hline Mnemonic & Description \\
\hline \(\mathrm{AV}_{\text {DD }}\) & Analog Power Supply. +5 V or +3.3 V . \\
\hline \(\mathrm{DV}_{\mathrm{DD}}\) & Digital Power Supply. \\
\hline AGND & Ground reference point for analog circuitry. \\
\hline DGND & Ground reference point for digital circuitry. \\
\hline \(\mathrm{V}_{\text {BIAS }}\) & This is the midpoint for the DAC outputs. The analog output from the DACs swings around this point. \\
\hline REFOUT & Reference Output; this is a bandgap reference and is typically 1.23 V . \\
\hline DB9-DB2 & Data Inputs. DB9 to DB2 are the 8 MSBs of the data word. DB9 and DB8 function also as the 2 LSBs of the 10-bit word when BYTE loading structure is used. \\
\hline DB0 & Data Input. Functions as the LSB when in the 10-bit parallel mode. \\
\hline DB1/(HBYTE/LBYTE) & Data Input in 10-bit parallel mode. Functions as a high byte and low byte enable when BYTE loading structure is selected. \\
\hline A0, A1, A2 & DAC Address Inputs. These digital inputs are used in conjunction with \(\overline{\mathrm{CS}}\) and \(\overline{\mathrm{WR}}\) to determine which DAC channel control register or DAC data register is loaded from the input register. \\
\hline \(\overline{\mathrm{CS}}\) & Chip Select. Active low logic input. \\
\hline \(\overline{\mathrm{WR}}\) & Write Input \(\overline{\mathrm{WR}}\) is an active low logic input which is used in conjunction with \(\overline{\mathrm{CS}}\) and the address pins to write data to the relevant registers. \\
\hline \(\overline{\text { LDAC }}\) & Asynchronous \(\overline{\text { LDAC }}\) Input. When this digital input is taken low, all DAC registers are simultaneously updated with the contents of the DAC data registers. \\
\hline \(\overline{\text { CLR }}\) & Asynchronous \(\overline{C L R}\) Input. When this input is taken low, all Main DAC outputs are cleared either to \(\mathrm{V}_{\text {BIAS }}\) or to \(\mathrm{V}_{\text {BIAS }} / 16\) volts. This input does not affect the operation of the Sub DAC. \\
\hline \(\overline{\text { COMP }}\) & Compensation Pin. This is a compensation pin for the internal \(\mathrm{V}_{\mathrm{DD}} / 2\) reference and should be decoupled with a \(0.1 \mu \mathrm{~F}\) capacitor to analog ground. \\
\hline Mode & Logic Input. Logic enables writing to the DAC input register, a logic 1 enables writing to the selected DACs control register. \\
\hline \(\mathrm{V}_{\text {OUTA }}-\mathrm{V}_{\text {OUTD }}\) & Analog output voltages from the DACs. \\
\hline \(\mathrm{V}_{\text {OUTE }}-\mathrm{V}_{\text {OUTH }}\) & Analog output voltages from the DACs. \\
\hline
\end{tabular}

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

\section*{INTERFACE SECTION (SERIAL)}

The AD7804-S and AD7808-S are serial input devices. Three lines control the serial interface, \(\overline{\text { FSIN }}\), CLKIN and SDIN. The timing diagram is shown in Figure 1.
When the \(\overline{\text { FSIN }}\) input goes low, data appearing on the SDIN line is clocked into the input register on each falling edge of CLKIN. When sixteen bits have been received, input register loading is automatically disabled until the next falling edge of \(\overline{\text { FSIN }}\) is detected. Table I shows the loading sequence for both the AD7804-S and the AD7808-S system control register, Table II shows the sequence for the channel control register and Table III the sequence for loading data to the DAC data registers. Figure 3 shows the internal registers associated with the AD7804-S and AD7808-S serial interface DACs. Only one DAC structure is shown for clarity.


Figure 3. AD7804-S and AD7808-S Internal Registers

DB15 and DB14 (MD1 and MD0) determine whether a write cycle accesses the control registers or the DAC data registers. When the system control register is selected by writing zeros to the modes bits MD1 and MD0, the address bits are ignored as the system control register controls all DACs in the package. When MD1 \(=0\) and \(\operatorname{MD} 0=1\), writing is to the channel control register. Only the DAC selected by the address bits will be affected by writing to this register. Each individual DAC has a channel control register.
The DACs data registers are addressed by writing a one to both MD1 and MD0 (DB15 and DB14 of the input word). DB13 determines whether writing is to the Main DAC data register or to the Sub DAC data register. The Main DAC is 10 bits wide and the Sub DAC is 8 bits wide. Thus when writing to the Sub DAC, DB9 and DB8 become don't cares. The Sub DAC is used the shift the complete transfer function of the Main DAC around its \(V_{\text {BIAS }}\) point. The Sub DAC has \(1 / 4\) LSB resolution and will enable the transfer function to be shifted by \(\pm \mathrm{V}_{\mathrm{BIAS}} / 16\).
When the \(\overline{\text { LDAC }}\) line goes low, all DAC registers in the device are simultaneously loaded with the contents of their respective DAC data registers, and the outputs change accordingly.
Bringing the CIR line low resets the DAC data and DAC registers. This hardware clear only effects the Main DAC, the Sub DAC is not effected by issuing a hardware clear to the part. This operation sets the analog output of the Main DAC to VIIAS 16 volts when offset binary coding is selected and the output is set to \(V_{\mathrm{BIA}}\) when twos complement coding is used.

Table I. AD7804-S/AD7808-S System Control Register Loading Sequence
MSB
LSB
\begin{tabular}{|l|l|l|l|l|l|l|l|l|l|l|l|l|l|l|}
\hline MD1 \(=0\) & MD0 \(=0\) & X & X & X & X & X & X & 0 & BIN \(/ \overline{\text { COMP }}\) & PD & \(\overline{\mathrm{SSTBY}}\) & \(\overline{\mathrm{SCLRM}}\) & \(\overline{\mathrm{SCLRS}}\) & X \\
\hline
\end{tabular}

Table II. AD7804-S/AD7808-S Channel Control Register Loading Sequence

\begin{tabular}{|l|l|l|l|l|l|l|l|l|l|l|l|l|l|l|l|}
\hline \(\mathrm{MD} 1=1\) & \(\mathrm{MD} 0=0\) & X & A 2 & A 1 & A 0 & X & X & X & X & X & \(\overline{\mathrm{STBY}}\) & \(\overline{\mathrm{CLR}}\) & MX 0 & MX 1 & 0 \\
\hline
\end{tabular}

Table III. AD7804-S/AD7808-S DAC Data Register Loading Sequence
DB15 (MSB) \(\quad\) DB0 (LSB)
\begin{tabular}{|l|l|l|l|l|l|l|l|l|l|l|l|l|l|l|l|}
\hline MD1 = 1 & MD0 \(=1\) & \(\overline{\text { MAIN }} / \mathrm{SUB}\) & A 2 & A 1 & A 0 & DB 9 & DB 8 & DB 7 & DB 6 & DB 5 & DB 4 & DB 3 & DB 2 & DB 1 & DB 0 \\
\hline
\end{tabular}

X = Don't Care.

\footnotetext{
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}

\section*{AD7804/AD7808}

\section*{INPUT/CONTROL REGISTERS}

Two mode bits (MD1 and MD0), which are the two MSBs of the serial word written to the AD7804-S or the AD7808-S, are used to determine whether writing is to the DAC registers or the control registers for these parts. These parts contain a system control register for controlling the operation of all DACs in the package as well as a channel control register for controlling the operation of each individual DAC. All registers are write-only registers. The following table shows how to access these registers.

Table IV. Register Selection
\begin{tabular}{l|l|l}
\hline MD1 & MD0 & Function \\
\hline 0 & 0 & Write Enable to System Control Register \\
0 & 1 & Write Enable to Channel Control Register \\
1 & 1 & Write Enable to DAC Data Registers \\
\hline
\end{tabular}

Figures 1-3 show the contents of the above registers.

\section*{DAC SELECTION (A2, A1, A0)}

Bits A2, A1 and A0 in the input register are used to address a specific DAC. The following tables show how the DACs are selected.

Table V. AD7808-S DAC Selection
\begin{tabular}{l|l|l|l}
\hline A2 & A1 & A0 & Function \\
\hline 0 & 0 & 0 & DAC A Selected \\
0 & 0 & 1 & DAC B Selected \\
0 & 1 & 0 & DAC C Selected \\
0 & 1 & 1 & DAC D Selected \\
1 & 0 & 0 & DAC E Selected \\
1 & 0 & 1 & DAC F Selected \\
1 & 1 & 0 & DAC G Selected \\
1 & 1 & 1 & DAC H Selected \\
\hline
\end{tabular}

\section*{SYSTEM CONTROL REGISTER (MD1 \(=0\), MD0 \(=0\) )}

This register has control over all DACs in the package. The control bits include power down (PD), DAC input coding select (BIN/COMP), global standby ( \(\overline{\mathrm{SSTBY}}\) ) and a global clear of all Main DACs ( \(\overline{\mathrm{SCLRM}}\) ) and a global clear of all Sub DACs ( \(\overline{\text { SCLRS }}\) ). The function of these bits is as follows.

\section*{POWER DOWN (PD)}

This bit in the control register is used to shut down the complete device. With a 1 in this position, the reference and all DACs are put into low power mode. Writing a 0 to this bit puts the part in the normal operating mode. When in power-down mode the contents of all registers are retained and are valid when the device is taken out of standby.

\section*{CODING (BIN/COMP)}

This bit in the global control register allows the user to select one of two input coding schemes. The available schemes are twos complement coding and offset binary coding. All DACs will be configured with the same input coding scheme. Writing a 0 to the control register selects twos complement coding, while writing a 1 to this bit in the control register selects offset binary coding
With twos complement coding selected, the output voltage from the Main DAC can be calculated as follows:
\[
V_{O U T}=V_{B A S}+1.875 \times V_{B L A S} \times N A / 1024
\]

Where \(N A\) is the decimal equivalent of the twos complement input code. NA tanges from -512 to +511 . See Table IV for \(V_{\text {bias }}\) input.
With offset binary coding selected the output voltage from the Main DAC can be calculated as follows:
\[
V_{O U T}=V_{B I A S}+1.875 \times V_{B I A S} \times((N A-512) / 1024)
\]

Where \(N A\) is the decimal equivalent of the offset binary input code. \(N A\) ranges from 0 to 1023 . See Table IV for \(\mathrm{V}_{\text {BIAS }}\) input.

Table VI. AD7804-S DAC Selection
\begin{tabular}{l|l|l|l}
\hline A2 & A1 & A0 & Function \\
\hline \(\mathbf{X}\) & 0 & 0 & DAC A Selected \\
\(\mathbf{X}\) & 0 & 1 & DAC B Selected \\
\(\mathbf{X}\) & 1 & 0 & DAC C Selected \\
\(\mathbf{X}\) & 1 & 1 & DAC D Selected \\
\hline
\end{tabular}

\footnotetext{
\(\mathrm{X}=\) Don't Care.
}

\footnotetext{
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}

\section*{SYSTEM STANDBY ( \(\overline{\text { SSTBY }}\) )}

This bit allows all the DACs in the package to be put into low power mode simultaneously. Writing a 0 to the \(\overline{\text { SSTBY }}\) bit in the system control register puts all DACs into standby mode. The following changes take place on writing a 0 to this bit. All linear circuitry is switched off. The V \(\mathrm{V}_{\text {OUT }}\) from all DACs is connected through a high impedance to ground. The DACs come out of power-down mode when a 1 is written to the \(\overline{\text { SSTBY }}\) bit. The contents of other locations in the control register are retained when the device is placed in power-down mode and are valid when normal operation is restored.

\section*{SYSTEM SOFTWARE CLEAR FUNCTIONS ( \(\overline{\text { SCLRM, }}\) SCLRS)}

This function allows the user to clear the contents of all the DAC registers in software. There are two bits available, one to clear all Main DACs and the second to clear all Sub DACs. The output of the Main DAC can be cleared to one of two places depending on the input coding used. Input coding is also programmable through the system control register. If twos complement coding is selected then issuing a software clear will reset the output of the Main DAC to mid-scale ( \(V_{\text {BIAS }}\) ). If offset binary coding is selected the output will be reset to \(\mathrm{V}_{\text {BIAS }} / 16\) following the execution of a software clear. The Sub DAC will be cleared to midscale regardless of the input coding selected. Writing a zero to the \(\overline{\text { SCLRM }}\) or \(\overline{\text { SCLRS }}\) bit in the control register clears the DACs outputs. A 1 in these bit positions puts the DAC in normal operating mode.

CHANNEL CONTROL REGISTER (MD1 \(=1, M D 0=1\) ) This register allows the user to have control over individual DACs in the package. The control bits in this register include standby ( \(\overline{\text { STBY }}\) ), individual DAC clear ( \(\overline{\mathrm{CLR}}\) ) and multiplexer output selection (MX1 and MX0). The function of these bits is as follows.

\section*{STANDBY ( \(\overline{\text { STBY }}\) )}

This bit allows the selected DAC in the package to be put into low power mode. Writing a 0 to the \(\overline{\text { STBY }}\) bit in the individual control register puts the selected DAC into standby mode. The following changes take place on writing a zero to this bit. All linear circuitry is switched off. The V VUT from the DAC is connected through a high impedance to ground. The DAC is returned to normal operation by writing a 1 to the \(\overline{\text { STBY }}\) bit. The contents of other locations in the control register are retained when the device is placed in power-down mode and are valid when normal operation is restored.

\section*{SOFTWARE CLEAR FUNCTION ( \(\overline{\mathrm{CLR}}\) )}

This function allows the user to clear the contents of the selected DAC latch in software. This software clear, clears only the Main DAC contents of the Sub DAC. DAC register is unaffected by a CLR operation. The output of the Main DAC can be cleared to one of two places depending on the input coding used. Input coding is also programmable through the global control register. If twos complement coding is selected, then issuing a software clear will reset the output of the Main DAC to midscale ( \(\mathrm{V}_{\text {BIAS }}\) ). If offset binary coding is selected, the output will be reset to \(\mathrm{V}_{\text {BIAS }} / 16\) following the execution of a software clear. Writing a 0 to the \(\overline{\mathrm{CLR}}\) bit in the control register clears the DACs output. A 1 in the \(\overline{C L R}\) bit position puts the DAC in normal operating mode.

\section*{MULTIPLEXER SELECTION (MX1, MX0)}

These two bits are used to select the reference input for the selected DAC. The following table shows the options available.

Table VII. Multiplexer Output Selection
\begin{tabular}{l|c|l}
\hline \(\mathbf{M X 1}\) & MX0 & V \(_{\text {BIAS }}\) \\
\hline 0 & 1 & INTERNAL V \(_{\text {REF }}\) \\
1 & 1 & V \(_{\text {DD }} / 2\) \\
1 & 0 & EXT V VIAS \\
\hline
\end{tabular}

\section*{SUB DAC DATA REGISTER}

Figure 3 shows the loading sequence for writing to the data registers of the DACs. DB13 determines whether writing is to the Main or Sub DACs data register. A one in this position selects the addressed Sub DACs data register. The Sub DAC is eightbits wide and thus DB9 and DB8 are don't cares when writing to the Sub DAC. This Sub DAC allows the complete transfer function of each individual DAC to be shifted around the V VIAS point. This is achieved by using a Sub DAC whose output is either added or subtracted to the output of the Main DAC. This Sub DAC has a span of \(\pm V_{\text {DAC }} / 16\) with \(1 / 4\)-bit resolution. An 8 -bit DAC is used to implement this function. The output of this Sub DAC is guaranteed monotonic. The coding scheme for the Sub DAC is programmed through the control register. With offset binary coding the transfer function for the Sub DAC is
\[
V_{B I A S} / 16 \times(2 \times N A / 256-1)
\]
where \(N A\) is the digital code written to the Sub DAC and varies from 0 to 255 . See Table IV for \(V_{\text {BIAS }}\) input.
With twos complement coding the transfer function for the Sub DAC is:
\[
V_{B I A S} / 8 \times(N B / 256)
\]
where \(N B\) is the digital code written to the Sub DAC and varies from -128 to 127. See Table IV for \(\mathrm{V}_{\text {BIAS }}\) input.
The DAC register for the relevant Sub DAC is selected by writing 0,1 to the mode bits MD1 and MD0.

\footnotetext{
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}

\section*{AD7804/AD7808}

\section*{CONTROL REGISTER (PARALLEL VERSION)}

Access to the control register of the AD7804-P and the AD7808-P is achieved by taking the mode pin to a logic high. The control register of these DACs is eight bits wide and is configured as in Tables V and VI. There are two control registers associated with the part. System control register which looks after the input coding, data format, power down, global clear and global standby. The channel control register contains bits that effect the operation of the selected DAC. The external address bits are used to select the DACs. When mode is high, the two mode bits select which of the control registers is being addressed.

Table VIII. AD7804-P and AD7808-P System Control Register Configuration
DB9
DB0
\begin{tabular}{|l|l|l|l|l|l|l|l|l|}
\hline 0 & X & \(\overline{\text { SCLRS }}\) & \(\overline{\text { SCLRM }}\) & \(\overline{\text { SSTBY }}\) & PD & BIN \(/ \overline{\mathrm{COMP}}\) & \(\overline{10} / 8\) & X \\
MD0 \(=0\) \\
\hline
\end{tabular}

Table IX. AD7804-P and AD7808-P Channel Control Register Configuration
DB9
DB0
\begin{tabular}{|l|l|l|l|l|l|l|l|l|l|}
\hline X & MX1 & MX0 & \(\overline{\mathrm{CLR}}\) & \(\overline{\text { STBY }}\) & X & X & \(\overline{\text { MAIN }} / \mathrm{SUB}\) & X & MD0 \(=1\) \\
\hline
\end{tabular}

Each DAC has a separate channel control register. The following is a brief discussion on each bit in these registers.

\section*{SYSTEM OR CHANNEL CONTROL REGISTER SELECTION} MD0
\(0 \quad\) This enables writing to the system control register. The contents of this are shown in Table VIII. Mode must be low to access this control register.

1 This enables writing to the channel control register. The contents of this are shown in Table IX. Mode must also be low to access this control register.

\section*{DATA FORMAT}
\(\overline{10} / 8\)
\(0 \quad\) 10-Bit Parallel Loading Structure (Default on Power-Up).

\section*{INPUT CODING}

BIN/ \(\overline{\text { COMP }}\)
0 Twos Complement Coding.
1 Offset Binary Coding (Default on Power-Up).

\section*{POWER DOWN}

PD
0 Normal Operation.
1 Complete Power Down of Device (Default on Power-Up).

\section*{SYSTEM STANDBY}

\section*{SSTBY}

0 All DACs in the Package Put in Standby Mode.
1 Normal Operation (Default on Power-Up).

\section*{SYSTEM CLEAR}

\section*{\(\overline{\text { SCLRM }} \& \overline{\text { SCLRS }}\)}

0 All DACs in the package are cleared to a known state depending on the coding scheme selected. The SCLRM bit clears the Main DACs while the \(\overline{\text { SCLRS }}\) bit clears the Sub DACs. The Sub DAC is always cleared to midscale regardless of the coding. The Main DAC is cleared to different levels depending on the coding scheme. With offset binary coding the output is cleared to \(\mathrm{V}_{\text {BIAS }} / 16\). With twos complement coding the output is cleared to \(V_{\text {BIAS }}\).

1 Normal Operation (Default on Power-Up).

\section*{MAIN DAC OR SUB DAC SELECTION}

\section*{MAIN/ \(\overline{\text { SUB }}\)}

0 When Mode is taken low, writing to the AD7804/AD7808 loads data to the input register of the selected Sub DAC.
1. Writing to the DAC with MODE low loads data to the input register of the selected Main DAC (Default Condition on Power-Up).

1 Byte Loading Structure ( \(8+2\) Loading Left Justified Data).

in byte mode dB1 becomes hbyte/Lbyte enable.
\(0=\overline{\text { HBYTE }}, 1\) = LBYTE.
Figure 4. AD7804-P and AD7808-P Parallel \& Byte Loading Structure

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\section*{FEATURES}

Two 12-Bit MDACS with Output Amplifiers 4-Quadrant Multiplication
Space-Saving 0.3", 24-Pin DIP and 24-Terminal SOIC Package
Parallel Loading Structure: AD7847
\((8+4)\) Loading Structure: AD7837

\section*{APPLICATIONS}

\author{
Automatic Test Equipment \\ Function Generation \\ Waveform Reconstruction \\ Programmable Power Supplies \\ Synchro Applications
}

\section*{GENERAL DESCRIPTION}

The AD7837/AD7847 is a complete, dual, 12-bit multiplying digital-to-analog converter with output amplifiers on a monolithic CMOS chip. No external user trims are required to achieve full specified performance.
Both parts are microprocessor compatible, with high speed data latches and interface logic. The AD7847 accepts 12-bit parallel data which is loaded into the respective DAC latch using the \(\overline{\text { WR input and a separate Chip Select input for each DAC. The }}\) AD7837 has a double-buffered 8-bit bus interface structure with data loaded to the respective input latch in two write operations. An asynchronous \(\overline{\text { LDAC }}\) signal on the AD7837 updates the DAC latches and analog outputs.
The output amplifiers are capable of developing \(\pm 10 \mathrm{~V}\) across a \(2 \mathrm{k} \Omega\) load. They are internally compensated with low input offset voltage due to laser trimming at wafer level.
The amplifier feedback resistors are internally connected to \(\mathrm{V}_{\text {OUt }}\) on the AD7847.
The AD7837/AD7847 is fabricated in Linear Compatible CMOS ( LC \(^{2}\) MOS), an advanced, mixed technology process that combines precision bipolar circuits with low power CMOS logic.
A novel low leakage configuration (U.S. Patent No. \(4,590,456\) ) ensures low offset errors over the specified temperature range.

This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

\section*{PRODUCT HIGHLIGHTS \\ 1.}
1. The AD7837/AD7847 is a dual, 12-bit, voltage-out MDAC on a single chip. This single chip design offers considerable space saving and increased reliability over multichip designs.
2. The AD7837 and the AD7847 provide a fast versatile interace to 8 -bit or 16 -bit data bus structures.

ace to 8-bit or 16-bit data bus structures.

\(\mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}\) [ \(\mathrm{V}_{\text {OUT }}\) connected to \(\mathrm{R}_{\mathrm{FB}}\) AD7837]. All specifications \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) unless otherwise noted.)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Parameter & A Version & B Version & S Version & Units & Test Conditions/Comments \\
\hline \multicolumn{6}{|l|}{STATIC PERFORMANCE} \\
\hline Resolution & 12 & 12 & 12 & Bits & \\
\hline Relative Accuracy \({ }^{2}\) & \(\pm 1\) & \(\pm 1 / 2\) & \(\pm 1\) & LSB max & \\
\hline Differential Nonlinearity \({ }^{2}\) & \(\pm 1\) & \(\pm 1\) & \(\pm 1\) & LSB max & Guaranteed Monotonic \\
\hline Zero Code Offset Error \({ }^{2}\) & & & & & \\
\hline @ \(+25^{\circ} \mathrm{C}\) & \(\pm 2\) & \(\pm 2\) & \(\pm 2\) & mV max \({ }^{\text {* }}\) & DAC Latch Loaded with All 0s \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & \(\pm 4\) & \(\pm 3\) & \(\pm 5\) & mV max & Temperature Coefficient \(= \pm 5 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}\) typ \\
\hline Gain Error \({ }^{\text {max }}\) & & & & & \\
\hline @ \(+25^{\circ} \mathrm{C}\) & \(\pm 5\) & \(\pm 2\) & \(\pm 5\) & LSB max & DAC Latch Loaded with All 1 s \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & \(\pm 7\) & \(\pm 4\) & \(\pm 7\) & LSB max & Temperature Coefficient \(= \pm 2 \mathrm{ppm}\) of FSR \(/{ }^{\circ} \mathrm{C}\) typ \\
\hline \multicolumn{6}{|l|}{REFERENCE INPUTS} \\
\hline \(\mathrm{V}_{\text {REF }}\) Input Resistance & 8/13 & 8/13 & 8/13 & \(\mathrm{k} \Omega\) min \(/\) max & Typical Input Resistance \(=10 \mathrm{k} \Omega\) \\
\hline \(\mathrm{V}_{\text {Refa }}, \mathrm{V}_{\text {REFB }}\) Resistance Matching & \(\pm 3\) & \(\pm 3\) & \(\pm 3\) & \% max & Typically \(\pm 0.5 \%\) \\
\hline \multicolumn{6}{|l|}{DIGITAL INPUTS} \\
\hline Input High Voltage, \(\mathrm{V}_{\text {INH }}\) & 2.4 & 2.4 & 2.4 & \(V_{\text {min }}\) & \\
\hline Input Low Voltage, \(\mathrm{V}_{\text {INL }}\) & 0.8 & 0.8 & 0.8 & V max & \\
\hline Input Current & \(\pm 1\) & \(\pm 1\) & \(\pm 1\) & \(\mu \mathrm{A}\) max & Digital Inputs at 0 V and \(\mathrm{V}_{\mathrm{DD}}\) \\
\hline Input Capacitance \({ }^{3}\) & 8 & 8 & 8 & pF max & \\
\hline \multicolumn{6}{|l|}{ANALOG OUTPUTS} \\
\hline DC Output Impedance & 0.2 & 0.2 & 0.2 & \(\Omega\) typ & \\
\hline Short Circuit Current & 15 & 15 & 15 & mA typ & \(\mathrm{V}_{\text {OUT }}\) Connected to AGND \\
\hline \multicolumn{6}{|l|}{POWER REQUIREMENTS \({ }^{4}\)} \\
\hline \(\mathrm{V}_{\text {DD }}\) Range & 14.25/15.75 & 14.25/15.75 & 14.25/15.75 & V min/max & \\
\hline \(\mathrm{V}_{\text {ss }}\) Range & -14.25/-15.75 & -14.25/-15.75 & -14.25/-15.75 & V min/max & \\
\hline Power Supply Rejection & & & & & \\
\hline \(\Delta \mathrm{Gain} / \Delta \mathrm{V}_{\text {DD }}\) & \(\pm 0.1\) & \(\pm 0.1\) & \(\pm 0.1\) & \%per \%max & \(\mathrm{V}_{\mathrm{DD}}=15 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\text {REF }}=-10 \mathrm{~V}\) \\
\hline \(\Delta \mathrm{Gain} / \Delta \mathrm{V}_{\text {ss }}\) & \(\pm 0.1\) & \(\pm 0.1\) & \(\pm 0.1\) & \%per \%max & \(\mathrm{V}_{\text {Ss }}=-15 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\text {REF }}=+10 \mathrm{~V}\) \\
\hline \(\mathrm{I}_{\mathrm{DD}}\) & 10 & 10 & 10 & mA max & Output Unloaded. Typically 5 mA \\
\hline \(\mathrm{I}_{\text {ss }}\) & 6 & 6 & 6 & mA max & Output Unloaded. Typically 4 mA \\
\hline \multicolumn{6}{|l|}{AC CHARACTERISTICS \({ }^{2,3}\)} \\
\hline Voltage Output Setting Time & 4 & 4 & 4 & \(\mu \mathrm{styp}\) & Setting Time to Within \(\pm 1 / 2\) LSB of Final Value. DAC Latch Alternately Loaded with All 0 s and All 1s \\
\hline Slew Rate & 7 & 7 & 7 & & \\
\hline Digital-to-Analog Glitch Impulse & 175 & 175 & 175 & \[
\mathrm{nV} \text { secs typ }
\] & DAC Latch Alternately Loaded with 01 . . . 11 and 10 . . 00 \\
\hline Channel-to-Channel Isolation & & & & & \\
\hline \(\mathrm{V}_{\text {REFA }}\) to \(\mathrm{V}_{\text {OUtB }}\) & -95 & -95 & -95 & dB typ & \begin{tabular}{l}
\(\mathrm{V}_{\mathrm{REFA}}=20 \mathrm{~V} \mathrm{p}-\mathrm{p}, 10 \mathrm{kHz}\) Sine Wave. \\
DAC Latches Loaded with All Os
\end{tabular} \\
\hline \(\mathrm{V}_{\text {REFB }}\) to \(\mathrm{V}_{\text {OUTA }}\) & -95 & -95 & -95 & dB typ & \begin{tabular}{l}
\(\mathrm{V}_{\text {REFB }}=20 \mathrm{~V} \mathrm{p}-\mathrm{p}, 10 \mathrm{kHz}\) Sine Wave. \\
DAC Latches Loaded with All Os
\end{tabular} \\
\hline Multiplying Feedthrough Error & -90 & -90 & -90 & dB typ & \begin{tabular}{l}
\[
\mathrm{V}_{\mathrm{REF}}=20 \mathrm{~V} \text { p-p, } 10 \mathrm{kHz} \text { Sine Wave. }
\] \\
DAC Latch Loaded with All Os
\end{tabular} \\
\hline Unity Gain Small Signal BW & 600 & 600 & 600 & kHz typ & \begin{tabular}{l}
\(\mathrm{V}_{\mathrm{REF}}=100 \mathrm{mV} \mathrm{p}-\mathrm{p}\) Sine Wave. DAC \\
Latch Loaded with All 1s
\end{tabular} \\
\hline Full Power BW & 110 & 110 & 90 & kHz typ & \begin{tabular}{l}
\(\mathrm{V}_{\mathrm{REF}}=20 \mathrm{~V}\) p-p Sine Wave. DAC \\
Latch Loaded with All 1s
\end{tabular} \\
\hline Total Harmonic Distortion & -88 & -88 & -88 & dB typ & \(\mathrm{V}_{\mathrm{REF}}=6 \mathrm{~V} \mathrm{rms}, 1 \mathrm{kHz}\). DAC Latch Loaded with All 1s \\
\hline Digital Crosstalk & 10 & 10 & 10 & nV secs typ & Code Transition from All 0 s to All 1 s \\
\hline Output Noise Voltage @ \(+25^{\circ} \mathrm{C}\) ( 0.1 Hz to 10 Hz ) & 2 & 2 & 2 & \(\mu \mathrm{V}\) rms typ & See Typical Performance Graphs Amplifier Noise and Johnson Noise of \(\mathrm{R}_{\mathrm{FB}}\) \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Temperature Ranges are as follows: A, B Versions, \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\); S Version, \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\).
\({ }^{2}\) See Terminology.
\({ }^{3}\) Sample tested @ \(+25^{\circ} \mathrm{C}\) to ensure compliance.
\({ }^{4}\) The Devices are functional with \(\mathrm{V}_{\mathrm{DD}} / \mathbf{V}_{\mathrm{ss}}= \pm 12 \mathrm{~V}\) (See typical performance graphs.)
Specifications subject to change without notice.

TIMING CHARACTERISTICS \({ }^{1,2}\)
\begin{tabular}{l|l|l|l}
\hline Parameter & \begin{tabular}{l} 
Limit at T \(\mathbf{m i n}, \mathbf{T}_{\text {max }}\) \\
(A, B Versions)
\end{tabular} & \begin{tabular}{l} 
Limit at \(\mathbf{T}_{\text {min }}, \mathbf{T}_{\text {max }}\) \\
(S Version)
\end{tabular} & Units
\end{tabular}

NOTES
\({ }^{1}\) Sample tested @ \(+25^{\circ} \mathrm{C}\) to ensure compliance. All input signals are specified with \(\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%\) to \(90 \%\) of 5 V\()\) and timed from a voltage level of 1.6 V .
\({ }^{2}\) See Figures 3 and 5.
\({ }^{3}\) AD7837 only.

\section*{ABSOLUTE MAXIMUM RATINGS*}
( \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) unless otherwise noted)
\(\mathrm{V}_{\mathrm{DD}}\) to DGND, AGNDA, AGNDB \(\ldots . . .-0.3 \mathrm{~V}\) to +17 V
\(\mathrm{V}_{\mathrm{Ss}}{ }^{1}\) to DGND, AGNDA, AGNDB \(\ldots . . .+0.3 \mathrm{~V}\) to -17 V
\(\mathrm{V}_{\mathrm{REFA}}, \mathrm{V}_{\mathrm{REFB}}\) to AGNDA, AGNDB
\(\ldots . .\).
AGNDA, AGNDB to DGND . . . . . -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
\(\mathrm{V}_{\text {OUTA }}{ }^{2}, \mathrm{~V}_{\text {OUTB }}{ }^{2}\) to AGNDA, AGNDB
. . . . . . . . . . . . . . . . . . . . \(\mathrm{V}_{\text {Ss }}-0.3 \mathrm{~V}\) to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
\(\mathrm{R}_{\mathrm{FBA}}{ }^{3}, \mathrm{R}_{\mathrm{FBB}}{ }^{3}\) to AGNDA, AGNDB

Digital Inputs to DGND . . . . . . . -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
Operating Temperature Range Commercial/Industrial (A, B Versions) . . . \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) Extended (S Version) . . . . . . . . . . . . . . \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
Storage Temperature Range . . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Lead Temperature (Soldering, 10 secs) . . . . . . . . . . . \(+300^{\circ} \mathrm{C}\)
Power Dissipation (Any Package) to \(+75^{\circ} \mathrm{C}\). . . . . . 1000 mW
Derates above \(+75^{\circ} \mathrm{C}\) by \(10 \mathrm{~mW} /{ }^{\circ} \mathrm{C}\)

\section*{NOTES}
\({ }^{1}\) If \(\mathrm{V}_{\mathrm{SS}}\) is open circuited with \(\mathrm{V}_{\mathrm{DD}}\) and either AGND applied, the \(\mathrm{V}_{\mathrm{SS}}\) pin will float positive, exceeding the Absolute Maximum Ratings. If this possibility exists, a Schottky diode connected between \(\mathrm{V}_{\text {ss }}\) and AGND (cathode to AGND) ensures the Maximum Ratings will be observed.
\({ }^{2}\) The outputs may be shorted to voltages in this range provided the power dissipation of the package is not exceeded.
\({ }^{3}\) AD7837 only.
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Only one Absolute Maximum Rating may be applied at any one time.

\section*{ORDERING GUIDE}
\begin{tabular}{l|l|l|l}
\hline Model \({ }^{\mathbf{1}}\)
\end{tabular} \left\lvert\, \begin{tabular}{l} 
Temperature \\
Range
\end{tabular}\(\quad\)\begin{tabular}{l} 
Relative \\
Accuracy
\end{tabular} \begin{tabular}{l} 
Package \\
Option \({ }^{2}\)
\end{tabular}\right.

\section*{NOTES}
\({ }^{1}\) To order MIL-STD-883, Class B processed parts, add /883B to part number.
\({ }^{2} \mathrm{~N}=\) Plastic DIP; \(\mathrm{Q}=\) Cerdip; \(\mathrm{R}=\) SOIC. For outline information see Package Information section.

\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are inserted.

\section*{AD7837/AD7847}

\section*{TERMINOLOGY}

\section*{Relative Accuray (Linearity)}

Relative accuracy, or endpoint linearity, is a measure of the maximum deviation of the DAC transfer function from a straight line passing through the endpoints. It is measured after allowing for zero and full-scale errors and is expressed in LSBs or as a percentage of full-scale reading.

\section*{Differential Nonlinearity}

Differential nonlinearity is the difference between the measured change and the ideal 1 LSB change between any two adjacent codes. A specified differential nonlinearity of \(\pm 1\) LSB or less over the operating temperature range ensures monotonicity.

\section*{Zero Code Offset Error}

Zero code offset error is the error in output voltage from \(V_{\text {OUTA }}\) or \(\mathrm{V}_{\text {outb }}\) with all 0 s loaded into the DAC latches. It is due to a combination of the DAC leakage current and offset errors in the output amplifier.

\section*{Gain Error}

Gain error is a measure of the output error between an ideal DAC and the actual device output with all 1 s loaded. It does not include offset error.

\section*{Total Harmonic Distortion}

This is the ratio of the root-mean-square (rms) sum of the harmonics to the fundamental, expressed in dBs.

\section*{Multiplying Feedthrough Error}

This is an ac error due to capacitive feedthrough from the \(\mathrm{V}_{\text {REF }}\) input to \(\mathrm{V}_{\text {OUT }}\) of the same DAC when the DAC latch is loaded with all 0s.

\section*{Channel-to-Channel Isolation}

This is an ac error due to capacitive feedthrough from the \(\mathrm{V}_{\text {REF }}\) input on one DAC to \(\mathrm{V}_{\text {OUt }}\) on the other DAC. It is measured with the DAC latches loaded with all Os.

\section*{Digital Feedthrough}

Digital feedthrough is the glitch impulse injected from the digital inputs to the analog output when the data inputs change state, but the data in the DAC latches is not changed.

For the AD7837, it is measured with LDAC held high. For the AD7847, it is measured with \(\overline{\mathrm{CSA}}\) and \(\overline{\mathrm{CSB}}\) held high.

\section*{Digital Crosstalk}

Digital crosstalk is the glitch impulse transferred to the output of one converter due to a change in digital code on the DAC latch of the other converter. It is specified in nV secs.

\section*{Digital-to-Analog Glitch Impulse}

This is the voltage spike that appears at the output of the DAC when the digital code changes, before the output settles to its final value. The energy in the glitch is specified in nV secs and is measured for a 1 LSB change around the major carry transition ( 011111111111 to 100000000000 ).

\section*{Unity Gain Small Signal Bandwidth}

This is the frequency at which the small signal voltage output from the output amplifier is 3 dB below its dc level. It is measured with the DAC latch loaded with all 1 s .

\section*{Full Power Bandwidth}

This is the maximum frequency for which a sinusoidal input signal will produce full output at rated load with a distortion less than 3\%. It is measured with the DAC latch loaded with all 1 s .

AD7837 PIN CONFIGURATION


\section*{AD7847 PIN CONFIGURATION}

DIP \& SOIC


\section*{FEATURES}

\section*{Complete 14-Bit Voltage Output DAC}

Parallel and Serial Interface Capability 80dB Signal-to-Noise Ratio
Interfaces to High Speed DSP Processors e.g., ADSP-2100, TMS32010, TMS32020

45ns min WR Pulse Width
Low Power - 70mW typ.
Operates from \(\pm 5 \mathrm{~V}\) Supplies

\section*{GENERAL DESCRIPTION}

The AD7840 is a fast, complete 14 -bit voltage output D/A converter. It consists of a 14 -bit DAC, 3 V buried Zener reference, DAC output amplifier and high speed control logic.
The part features double-buffered interface logic with a 14 -bit input latch and 14-bit DAC latch. Data is loaded to the input latch in either of two modes, parallel or serial. This data is then transferred to the DAC latch under control of an asynchronous \(\overline{\text { LDAC }}\) signal. A fast data setup time of 21 ns allows direct parallel interfacing to digital signal processors and high speed 16-bit microprocessors. In the serial mode, the maximum serial data clock rate can be as high as 6 MHz .
The analog output from the AD7840 provides a bipolar output range of \(\pm 3 \mathrm{~V}\). The AD7840 is fully specified for dynamic performance parameters such as signal-to-noise ratio and harmonic distortion as well as for traditional dc specifications. Full power output signals up to 20 kHz can be created.
The AD7840 is fabricated in linear compatible CMOS (LC \({ }^{2}\) MOS), an advanced, mixed technology process that combines precision bipolar circuits with low power CMOS logic. The part is available in a 24 -pin plastic and hermetic dual-in-line package (DIP) and is also packaged in a 28 -terminal plastic leaded chip carrier (PLCC).

FUNCTIONAL BLOCK DIAGRAM



PIN CONFIGURATIONS

This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

AD7840 - SPECFICATIONS
\begin{tabular}{|c|c|c|c|c|c|}
\hline Parameter & J, \(\mathbf{A}^{1}\) & K, \(\mathbf{B}^{\mathbf{1}}\) & \(\mathbf{S}^{1}\) & Units & Test Conditions/Comments \\
\hline \begin{tabular}{l}
DYNAMIC PERFORMANCE \({ }^{2}\) \\
Signal to Noise Ratio \({ }^{3}\) (SNR) \\
Total Harmonic Distortion (THD) \\
Peak Harmonic or Spurious Noise
\end{tabular} & 76
-78
-78 & 78
-80
-80 & 76
\[
-78
\]
\[
-78
\] & \begin{tabular}{l}
dB min \\
dB max \\
dB max
\end{tabular} & \begin{tabular}{l}
\(\mathrm{V}_{\text {OUT }}=1 \mathrm{kHz}\) Sine Wave, \(\mathrm{f}_{\text {SAMPLE }}=100 \mathrm{kHz}\) \\
Typically 82 dB at \(+25^{\circ} \mathrm{C}\) for \(0<\mathrm{V}_{\text {Out }}<20 \mathrm{kHz}^{4}\) \\
\(\mathrm{V}_{\text {OUT }}=1 \mathrm{kHz}\) Sine Wave, \(\mathrm{f}_{\text {SAMPLE }}=100 \mathrm{kHz}\) \\
Typically -84 dB at \(+25^{\circ} \mathrm{C}\) for \(0<\mathrm{V}_{\text {Out }}<20 \mathrm{kHz}^{4}\) \\
\(\mathrm{V}_{\text {OUT }}=1 \mathrm{kHz}\) Sine Wave, \(\mathrm{f}_{\text {SAMPLE }}=100 \mathrm{kHz}\) \\
Typically -84 dB at \(+25^{\circ} \mathrm{C}\) for \(0<\mathrm{V}_{\text {Out }}<20 \mathrm{kHz}^{4}\)
\end{tabular} \\
\hline \begin{tabular}{l}
DC ACCURACY \\
Resolution \\
Integral Nonlinearity Differential Nonlinearity Bipolar Zero Error Positive Full Scale Error \({ }^{5}\) Negative Full Scale Error \({ }^{5}\)
\end{tabular} & \[
\begin{aligned}
& 14 \\
& \pm 2 \\
& \pm 0.9 \\
& \pm 10 \\
& \pm 10 \\
& \pm 10
\end{aligned}
\] & \[
\begin{aligned}
& 14 \\
& \pm 1 \\
& \pm 0.9 \\
& \pm 10 \\
& \pm 10 \\
& \pm 10
\end{aligned}
\] & \[
\begin{aligned}
& 14 \\
& \pm 2 \\
& \pm 0.9 \\
& \pm 10 \\
& \pm 10 \\
& \pm 10
\end{aligned}
\] & \begin{tabular}{l}
Bits \\
LSB max \\
LSB max \\
LSB max \\
LSB max \\
LSB max
\end{tabular} & Guaranteed Monotonic \\
\hline \begin{tabular}{l}
REFERENCE OUTPUT \({ }^{6}\) REF OUT @ \(+25^{\circ} \mathrm{C}\) \\
REF OUT TC Reference Load Change ( \(\Delta\) REF OUT vs. \(\Delta \mathrm{I}\) )
\end{tabular} & \[
\begin{aligned}
& 2.99 \\
& 3.01 \\
& \pm 60 \\
& \\
& -1
\end{aligned}
\] & \[
\begin{aligned}
& 2.99 \\
& 3.01 \\
& \pm 60 \\
& \\
& -1
\end{aligned}
\] & \[
\begin{aligned}
& 2.99 \\
& 3.01 \\
& \pm 60 \\
& \\
& -1
\end{aligned}
\] & \begin{tabular}{l}
V min \\
V max \\
\(\mathrm{ppm} /{ }^{\circ} \mathrm{C} \max\) \\
mV max
\end{tabular} & Reference Load Current Change (0-500 \(\mu \mathrm{A}\) ) \\
\hline \begin{tabular}{l}
REFERENCE INPUT \\
Reference Input Range \\
Input Current
\end{tabular} & \[
\begin{aligned}
& 2.85 \\
& 3.15 \\
& 50
\end{aligned}
\] & \[
\begin{aligned}
& 2.85 \\
& 3.15 \\
& 50
\end{aligned}
\] & \[
\begin{aligned}
& 2.85 \\
& 3.15 \\
& 50
\end{aligned}
\] & \begin{tabular}{l}
V min \\
V max \\
\(\mu \mathrm{A}\) max
\end{tabular} & \(3 \mathrm{~V} \pm 5 \%\) \\
\hline LOGIC INPUTS Input High Voltage, \(\mathrm{V}_{\text {INH }}\) Input Low Voltage, \(\mathrm{V}_{\text {INL }}\) Input Current, \(\mathrm{I}_{\text {IN }}\) Input Current (CS Input Only) Input Capacitance, \(\mathrm{C}_{\mathrm{IN}}{ }^{7}\) & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 10 \\
& \pm 10 \\
& 10
\end{aligned}
\] & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 10 \\
& \pm 10 \\
& 10
\end{aligned}
\] & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 10 \\
& \pm 10 \\
& 10
\end{aligned}
\] & \begin{tabular}{l}
V min \\
V max \\
\(\mu \mathrm{A}\) max \\
\(\mu \mathrm{A}\) max \\
pF max
\end{tabular} & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \% \\
& \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \% \\
& \mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{DD}} \\
& \mathrm{~V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{Ss}} \text { to } \mathrm{V}_{\mathrm{DD}}
\end{aligned}
\] \\
\hline ANALOG OUTPUT Output Voltage Range dc Output Impedance Short-Circuit Current & \[
\begin{aligned}
& \pm 3 \\
& 0.1 \\
& 20
\end{aligned}
\] & \[
\begin{aligned}
& \pm 3 \\
& 0.1 \\
& 20
\end{aligned}
\] & \[
\begin{aligned}
& \pm 3 \\
& 0.1 \\
& 20
\end{aligned}
\] & V Nom \(\Omega\) typ mA typ & - \\
\hline \begin{tabular}{l}
AC CHARACTERISTICS \({ }^{7}\) \\
Voltage Output Settling Time \\
Positive Full-Scale Change \\
Negative Full-Scale Change \\
Digital-to-Analog Glitch Impulse \\
Digital Feedthrough
\end{tabular} & \[
\begin{aligned}
& 4 \\
& 4 \\
& 10 \\
& 2
\end{aligned}
\] & \[
\begin{aligned}
& 4 \\
& 4 \\
& 10 \\
& 2
\end{aligned}
\] & \[
\begin{aligned}
& 4 \\
& 4 \\
& 10 \\
& 2
\end{aligned}
\] & \begin{tabular}{l}
\(\mu \mathrm{s}\) max \\
\(\mu \mathrm{s}\) max \\
nV secs typ \\
nV secs typ
\end{tabular} & \begin{tabular}{l}
Settling Time to within \(\pm 1 / 2\) LSB of Final Value \\
Typically \(2 \mu \mathrm{~s}\) \\
Typically \(2.5 \mu \mathrm{~s}\)
\end{tabular} \\
\hline ```
POWER REQUIREMENTS
    \(V_{D D}\)
    \(V_{\text {ss }}\)
    \(I_{D D}\)
    \(\mathrm{I}_{\mathrm{ss}}\)
    Power Dissipation
``` & \[
\begin{aligned}
& +5 \\
& -5 \\
& 14 \\
& 6 \\
& 100
\end{aligned}
\] & \[
\begin{aligned}
& +5 \\
& -5 \\
& 14 \\
& 6 \\
& 100
\end{aligned}
\] & \[
\begin{aligned}
& +5 \\
& -5 \\
& 15 \\
& 7 \\
& 110
\end{aligned}
\] & \begin{tabular}{l}
V nom \\
V nom mA max \(m A \max\) mW max
\end{tabular} & \begin{tabular}{l}
\(\pm 5 \%\) for Specified Performance \\
\(\pm 5 \%\) for Specified Performance \\
Output Unloaded, SCLK \(=+5 \mathrm{~V}\). Typically 10 mA \\
Output Unloaded, SCLK \(=+5 \mathrm{~V}\). Typically 4 mA \\
Typically 70 mW
\end{tabular} \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Temperature ranges are as follows: \(\mathrm{J}, \mathrm{K}\) Versions, 0 to \(+70^{\circ} \mathrm{C}\); A, B Versions, \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\); S Version, \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\).
\({ }^{2} \mathrm{~V}_{\text {OUT }}(\mathrm{pk}-\mathrm{pk})= \pm 3 \mathrm{~V}\).
\({ }^{3}\) SNR calculation includes distortion and noise components.
\({ }^{4}\) Using external sample-and-hold (see Testing the AD7840).
\({ }^{5}\) Measured with respect to REF IN and includes bipolar offset error.
\({ }^{6}\) For capacitive loads greater than 50 pF , a series resistor is required (see Internal Reference section).
\({ }^{7}\) Sample tested @ \(+25^{\circ} \mathrm{C}\) to ensure compliance.
Specifications subject to change without notice.

TIMING CHARACTERISTICS \({ }^{1,2}{ }^{2}{ }_{V_{00}}=+5 V \pm 5 \%, V_{S S}=-5 V \pm 5 \%\), aGVO \(=0\) ONO \(=0 V\). .
\begin{tabular}{|c|c|c|c|c|}
\hline Parameter & Limit at \(\mathbf{T}_{\text {min }}, \mathbf{T}_{\text {max }}\) (J, K, A, B Versions) & Limit at \(\mathbf{T}_{\text {min }}, \mathbf{T}_{\text {max }}\) (S Version) & Units & Conditions/Comments \\
\hline \(\mathrm{t}_{1}\) & 0 & 0 & ns min & \(\overline{\mathrm{CS}}\) to \(\overline{\mathrm{WR}}\) Setup Time \\
\hline \(\mathrm{t}_{2}\) & 0 & 0 & ns min & \(\overline{\mathrm{CS}}\) to \(\overline{\mathrm{WR}}\) Hold Time \\
\hline \(\mathrm{t}_{3}\) & 45 & 50 & ns min & WR Pulse Width \\
\hline \(\mathrm{t}_{4}\) & 21 & 28 & ns min & Data Valid to \(\overline{\text { WR }}\) Setup Time \\
\hline \(t_{5}\) & 10 & 15 & ns min & Data Valid to \(\overline{\mathrm{WR}}\) Hold Time \\
\hline \(t_{6}\) & 40 & 40 & ns min & LDAC Pulse Width \\
\hline \(\mathrm{t}_{7}\) & 50 & 50 & ns min & \(\overline{\text { SYNC }}\) to SCLK Falling Edge \\
\hline \(\mathrm{t}_{8}{ }^{3}\) & 150 & 200 & \(n s \min\) & SCLK Cycle Time \\
\hline \(\mathrm{t}_{9}\) & 30 & 40 & ns min & Data Valid to SCLK Setup Time \\
\hline \(\mathrm{t}_{10}\) & 75 & 100 & ns min & Data Valid to SCLK Hold Time \\
\hline \(\mathrm{t}_{11}\) & 75 & 100 & ns min & \(\overline{\text { SYNC }}\) to SCLK Hold Time \\
\hline
\end{tabular}

\footnotetext{
NOTE
\({ }^{1}\) Timing specifications in bold print are \(100 \%\) production tested. All other times are sample tested at \(+25^{\circ} \mathrm{C}\) to ensure compliance. All input signals are specified with \(\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%\) to \(90 \%\) of 5 V\()\) and timed from a voltage level of 1.6 V .
\({ }^{2}\) See Figures 6 and 8.
\({ }^{3}\) SCLK mark/space ratio is \(40 / 60\) to \(60 / 40\).
Specifications subject to change without notice.
}

\section*{ABSOLUTE MAXIMUM RATINGS*}
\begin{tabular}{|c|c|}
\hline \(\mathrm{V}_{\text {DD }}\) to AGND & . 3 V to +7 V \\
\hline \(\mathrm{V}_{\text {ss }}\) to AGND & 3 V to -7 V \\
\hline AGND to DGND & -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\) \\
\hline \(\mathrm{V}_{\text {Out }}\) to AGND. & . . . \(\mathrm{V}_{\text {ss }}\) to \(\mathrm{V}_{\mathrm{DD}}\) \\
\hline REF OUT to AGND & . . 0 V to \(\mathrm{V}_{\mathrm{DD}}\) \\
\hline REF IN to AGND & -0.3V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\) \\
\hline Digital Inputs to DGND & -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\) \\
\hline Operating Temperature Range & \\
\hline Commercial (J, K Versions) & . 0 to \(+70^{\circ} \mathrm{C}\) \\
\hline Industrial (A, B Versions) & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) \\
\hline Extended (S Version) & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

Storage Temperature Range . . . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Lead Temperature (Soldering, 10sec) . . . . . . . . . . . . \(+300^{\circ} \mathrm{C}\)
Power Dissipation (Any Package) to \(+75^{\circ} \mathrm{C}\). . . . . . . . . 450 mW Derates above \(+75^{\circ} \mathrm{C}\) by . . . . . . . . . . . . . . . . . . . . \(10 \mathrm{~mW} /{ }^{\circ} \mathrm{C}\)
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are inserted.


\section*{ORDERING GUIDE}
\begin{tabular}{l|l|l|l|l}
\hline Model \(^{\mathbf{1}}\) & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
SNR \\
(dB)
\end{tabular} & \begin{tabular}{l} 
Integral \\
Nonlinearity \\
(LSB)
\end{tabular} & \begin{tabular}{l} 
Package \\
Option \({ }^{2}\)
\end{tabular} \\
\hline AD7840JN & 0 to \(+70^{\circ} \mathrm{C}\) & 78 min & \(\pm 2 \max\) & \(\mathrm{~N}-24\) \\
AD7840KN & 0 to \(+70^{\circ} \mathrm{C}\) & 80 min & \(\pm 1 \max\) & \(\mathrm{~N}-24\) \\
AD7840JP & 0 to \(+70^{\circ} \mathrm{C}\) & 78 min & \(\pm 2 \max\) & \(\mathrm{P}-28 \mathrm{~A}\) \\
AD7840KP & 0 to \(+70^{\circ} \mathrm{C}\) & 80 min & \(\pm 1 \max\) & \(\mathrm{P}-28 \mathrm{~A}\) \\
AD7840AQ & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 78 min & \(\pm 2 \max\) & \(\mathrm{Q}-24\) \\
AD7840BQ & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 80 min & \(\pm 1 \max\) & \(\mathrm{Q}-24\) \\
AD7840SQ \(^{\mathbf{3}}\) & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 78 min & \(\pm 2 \max\) & \(\mathrm{Q}-24\) \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) To order MIL-STD-883, Class B processed parts, add /883B to part number.
Contact your local sales office for military data sheet and availability.
\({ }^{2} \mathrm{~N}=\) Plastic DIP; \(\mathbf{P}=\) Plastic Leaded Chip Carrier; \(\mathbf{Q}=\) Cerdip. For outline information see Package Information section.
\({ }^{3}\) This grade will be available to \(/ 883 \mathrm{~B}\) processing only.
\begin{tabular}{|c|c|c|}
\hline \[
\begin{aligned}
& \hline \text { DIP } \\
& \text { Pin } \\
& \text { No. }
\end{aligned}
\] & \begin{tabular}{l}
Pin \\
Mnemonic
\end{tabular} & Function \\
\hline 1 & \(\overline{\text { CS/SERIAL }}\) & Chip Select/Serial Input. When driven with normal logic levels, it is an active low logic input which is used in conjunction with \(\overline{\mathrm{WR}}\) to load parallel data to the input latch. For applications where \(\overline{\mathrm{CS}}\) is permanently low, an \(R, C\) is required for correct power-up (see \(\overline{L D A C}\) input). If this input is tied to \(V_{s s}\), it defines the AD7840 for serial mode operation. \\
\hline 2 & \(\overline{\text { WR/SYNC }}\) & Write/Frame Synchronization Input. In the parallel data mode, it is used in conjunction with \(\overline{\mathrm{CS}}\) to load parallel data. In the serial mode of operation, this pin functions as a Frame Synchronization pulse with serial data expected after the falling edge of this signal. \\
\hline 3 & D13/SDATA & Data Bit 13(MSB)/Serial Data. When parallel data is selected, this pin is the D13 input. In serial mode, SDATA is the serial data input which is used in conjunction with SYNC and SCLK to transfer serial data to the AD7840 input latch. \\
\hline 4 & D12/SCLK & Data Bit \(12 /\) Serial Clock. When parallel data is selected, this pin is the D12 input. In the serial mode, it is the serial clock input. Serial data bits are latched on the falling edge of SCLK when SYNC is low. \\
\hline 5 & D11/FORMAT & Data Bit 11/Data Format. When parallel data is selected, this pin is the D11 input. In serial mode, a logic 1 on this input indicates that the MSB is the first valid bit in the serial data stream. A logic 0 indicates that the LSB is the first valid bit (see Table I). \\
\hline 6 & D10/JUSTIFY & Data Bit 10/Data Justification. When parallel data is selected, this pin is the D10 input. In serial mode, this input controls the serial data justification (see Table I). \\
\hline 7-11 & D9-D5 & Data Bit. 9 to Data Bit 5. Parallel data inputs. \\
\hline 12 & DGND & Digital Ground. Ground reference for digital circuitry. \\
\hline 13-16 & D4-D1 & Data Bit 4 to Data Bit 1. Parallel data inputs. \\
\hline 17 & D0 & Data Bit 0 (LSB). Parallel data input. \\
\hline 18 & \(\mathrm{V}_{\mathrm{DD}}\) & Positive Supply, \(+5 \mathrm{~V} \pm 5 \%\). \\
\hline 19 & AGND & Analog Ground. Ground reference for DAC, reference and output buffer amplifier. \\
\hline 20 & \(\mathrm{V}_{\text {Out }}\) & Analog Output Voltage. This is the buffer amplifier output voltage. Bipolar output range ( \(\pm 3 \mathrm{~V}\) with REF \(\mathrm{IN}=+3 \mathrm{~V}\) ). \\
\hline 21 & \(\mathrm{V}_{\text {ss }}\) & Negative Supply Voltage, \(-5 \mathrm{~V} \pm 5 \%\). \\
\hline 22 & REF OUT & Voltage Reference Output. The internal 3V analog reference is provided at this pin. To operate the AD7840 with internal reference, REF OUT should be connected to REF IN. The external load capability of the reference is \(500 \mu \mathrm{~A}\). \\
\hline 23 & REF IN & Voltage Reference Input. The reference voltage for the DAC is applied to this pin. It is internally buffered before being applied to the DAC. The nominal reference voltage for correct operation of the AD7840 is 3 V . \\
\hline 24 & \(\overline{\text { LDAC }}\) & Load DAC. Logic input. A new word is loaded into the DAC latch from the input latch on the falling edge of this signal (see Interface Logic Information section). The AD7840 should be powered-up with \(\overline{\text { LDAC }}\) high. For applications where \(\overline{\text { LDAC }}\) is permanently low, an R, C is required for correct power-up (see Figure 19). \\
\hline
\end{tabular}


Table I. Serial Data Modes

\section*{FEATURES}

12-Bit CMOS MDAC with Output Amplifier 4-Quadrant Multiplication
Guaranteed Monotonic ( \(\mathrm{T}_{\text {Min }}\) to \(\mathrm{T}_{\text {MAX }}\) )
Space-Saving 0.3" DIPs and 24- or 28-Terminal Surface Mount Packages
Application Resistors On Chip for Gain Ranging, etc. Low Power LC²MOS

\section*{APPLICATIONS}

Automatic Test Equipment
Digital Attenuators
Programmable Power Supplies
Programmable Gain Amplifiers
Digital-to-4-20 mA Converters

\section*{GENERAL DESCRIPTION}

The AD7845 is the industry's first 4-quadrant multiplying D/A converter with an on-chip amplifier. It is fabricated on the \(L^{2}\) MOS process, which allows precision linear components and digital circuitry to be implemented on the same chip.
The 12 data inputs drive latches which are controlled by standard \(\overline{\mathrm{CS}}\) and \(\overline{\mathrm{WR}}\) signals, making microprocessor interfacing simple. For stand-alone operation, the \(\overline{\mathrm{CS}}\) and \(\overline{\mathrm{WR}}\) inputs can be tied to ground, making all latches transparent. All digital inputs are TTL and 5 V CMOS compatible.
The output amplifier can supply \(\pm 10 \mathrm{~V}\) into a \(2 \mathrm{k} \Omega\) load. It is internally compensated, and its input offset voltage is low due to laser trimming at wafer level. For normal operation, \(\mathrm{R}_{\mathrm{FB}}\) is tied to \(\mathrm{V}_{\text {OUT }}\), but the user may alternatively choose \(\mathrm{R}_{\mathrm{A}}, \mathrm{R}_{\mathrm{B}}\) or \(\mathrm{R}_{\mathrm{C}}\) to scale the output voltage range.

\section*{FUNCTIONAL BLOCK DIAGRAM}


\section*{PRODUCT HIGHLIGHTS}
1. Voltage Output Multiplying DAC

The AD7845 is the first DAC which has a full 4-quadrant multiplying capability and an output amplifier on chip. All specifications include amplifier performance.
2. Matched Application Resistors

Three application resistors provide an easy facility for gain ranging, voltage offsetting, etc.
3. Space Saving

The AD7845 saves space in two ways. The integration of the output amplifier on chip means that chip count is reduced. The part is housed in skinny 24 -pin, \(0.3^{\prime \prime}\) DIP, 28-terminal LCC and PLCC and 24-terminal SOIC packages.

This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.
\(\left(V_{D D}=+15 \mathrm{~V}, \pm 5 \%, V_{S S}=-15 \mathrm{~V}, \pm 5 \%, \mathrm{~V}_{\text {REF }}=+10 \mathrm{~V}\right.\),
AGND \(=\) DGND \(=0 \mathrm{~V}, \mathrm{~V}_{\text {out }}\) connected to \(\mathrm{R}_{\text {FB }} . V_{\text {out }}\) load \(=2 \mathrm{k} \mathrm{\Omega}, 100 \mathrm{pF}\). All specifications \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {mx }}\) unless otherwise stated.)


\section*{AC PERFORMANCE CHARACTERISTICS}

These characteristics are included for Design Guidance and are not subject to test.
\begin{tabular}{|c|c|c|c|c|c|c|c|c|}
\hline DYNAMIC PERFORMANCE Output Voltage Settling Time & 5 & 5 & 5 & 5 & 5 & 5 & \(\mu \mathrm{s}\) max & To 0.01\% of Full-Scale Range. \(\mathrm{V}_{\text {Out }}\) Load \(=2 \mathrm{k} \Omega, 100 \mathrm{pF}\). DAC Register Alternately Loaded with All 0 s and All 1 s . Typically \(2.5 \mu \mathrm{~s}\) at \(25^{\circ} \mathrm{C}\). \\
\hline Slew Rate & & 7 & 7 & 7 & & 7 & V/us typ & \(\mathrm{V}_{\text {OUT }}\) Load \(=2 \mathrm{k} \Omega, 100 \mathrm{pF}\). \\
\hline Digital-to-Analog & 450 & 450 & 450 & 450 & 450 & 450 & nV-s typ & Measured with \(\mathrm{V}_{\text {REF }}=0 \mathrm{~V}\). \\
\hline Glitch Impulse & & & & & & & & DAC Register Alternately Loaded with All Os and All 1 s . \\
\hline Multiplying Feedthrough Error \({ }^{3}\) & 5 & 5 & 5 & 5 & 5 & 5 & mV p-p typ & \(\mathrm{V}_{\text {REF }}= \pm 10 \mathrm{~V}, 10 \mathrm{kHz}\) Sine Wave DAC Register Loaded with All Os. \\
\hline Unity Gain Small Signal Bandwidth & 600 & 600 & 600 & 600 & 600 & 600 & kHz typ & \(\mathrm{V}_{\text {OUT }}, \mathrm{R}_{\mathrm{FB}}\) Connected. DAC Loaded \\
\hline & 600 & 600 & 600 & 600 & 600 & 600 & kHz typ & with All 1s. \(\mathrm{V}_{\text {REF }}=100 \mathrm{mV}\) p-p Sine Wave. \\
\hline Full Power Bandwidth & 250 & 250 & 250 & 250 & \({ }_{-20}^{250}\) & 250 & kHz typ & \begin{tabular}{l}
\(\mathrm{V}_{\text {OUT }}, \mathrm{R}_{\mathrm{FB}}\) Connected. DAC Loaded with All 1s. \(\mathrm{V}_{\text {REF }}=20 \mathrm{~V}\) p-p \\
Sine \(W\) ave. \(R_{L}=2 \mathrm{k} \Omega\).
\end{tabular} \\
\hline Total Harmonic Distortion & -90 & -90 & -90 & -90 & -90 & -90 & dB typ & \(\mathrm{V}_{\text {REF }}=6 \mathrm{~V}\) rms, 1 kHz Sine Wave. \\
\hline \multicolumn{9}{|l|}{OUTPUT CHARACTERISTICS \({ }^{5}\)} \\
\hline Open Loop Gain & 85 & 85 & 85 & 85 & 85 & 85 & dB min & \begin{tabular}{l}
\(\mathrm{V}_{\text {OUT }}, \mathrm{R}_{\mathrm{FB}}\) Not Connected \\
\(\mathrm{V}_{\text {OUT }}= \pm 10 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega\)
\end{tabular} \\
\hline Output Voltage Swing & \(\pm 10\) & \(\pm 10\) & \(\pm 10\) & \(\pm 10\) & \(\pm 10\) & \(\pm 10\) & \(V\) min & \(\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}\) \\
\hline Output Resistance & 0.2 & 0.2 & 0.2 & 0.2 & 0.2 & 0.2 & \(\Omega\) typ & \(\mathrm{R}_{\mathrm{FB}}, \mathrm{V}_{\text {Out }}\) Connected, \\
\hline Short Circuit Current @ \(+25^{\circ} \mathrm{C}\) & 15 & 15 & 15 & 15 & 15 & 15 & mA typ & \(V_{\text {out }}\) Shorted to AGND \\
\hline ( 0.1 Hz to 10 Hz ) @ + \(25^{\circ} \mathrm{C}\) & 2 & 2 & 2 & 2 & 2 & 2 & \(\mu \mathrm{V}\) rms typ & Amplifier and Johnson Noise \\
\hline \(\mathrm{f}=10 \mathrm{~Hz}\) & 250 & 250 & 250 & 250 & 250 & 250 & \(\mathrm{nV} \sqrt{\mathrm{Fz}}\) typ & of \(\mathrm{R}_{\mathrm{FB}}\) \\
\hline \(\mathrm{f}=100 \mathrm{~Hz}\) & 100 & 100 & 100 & 100 & 100 & 100 & \(\mathrm{nV} \sqrt{\mathrm{Hz}}\) typ & \\
\hline \(\mathrm{f}=1 \mathrm{kHz}\) & 50 & 50 & 50 & 50 & 50 & 50 & \(\mathrm{nV} \sqrt{\mathrm{Hz}}\) typ & \\
\hline \(\mathrm{f}=10 \mathrm{kHz}\) & 50 & 50 & 50 & 50 & 50 & 50 & \(\mathrm{nV} \sqrt{\mathrm{Fz}}\) typ & \\
\hline \(\mathrm{f}=100 \mathrm{kHz}\) & 50 & 50 & 50 & 50 & 50 & 50 & \(\mathrm{nV} \sqrt{\mathrm{Hz}}\) typ & \\
\hline
\end{tabular}

1 Temperature Ranges are as follows:
\({ }^{2}\) Sample tested to ensure compliance.
\({ }^{3}\) The metal lid on the ceramic \(\mathrm{D}-24 \mathrm{~A}\) package is connected to Pin 12 (DGND).
\({ }^{4}\) The device is functional with a power supply of \(\pm 12 \mathrm{~V}\).
\({ }^{5}\) Minimum specified load resistance is \(2 \mathbf{k} \Omega\).
Specifications subject to change without notice.

TIMING CHARACTERISTICS \(\left(v_{D D}=+15 \mathrm{~V}, \pm 5 \% . v_{S S}=-15 \mathrm{~V}, \pm 5 \% . \mathrm{V}_{\text {REF }}=+10 \mathrm{~V} . \operatorname{AGND}=\operatorname{DGND}=0 \mathrm{~V}.\right)\)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Parameter & Limit at
\[
\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}
\] & Limit at
\[
\begin{aligned}
& \mathrm{T}_{\mathrm{A}}=0 \text { to }+70^{\circ} \mathrm{C} \\
& \mathrm{~T}_{\mathrm{A}}=-25^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C}
\end{aligned}
\] & Limit at
\[
\begin{aligned}
& \mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C} \\
& \text { to }+125^{\circ} \mathrm{C}
\end{aligned}
\] & Units & Test Conditions/Comments \\
\hline \(\mathrm{t}_{\mathrm{cs}}\) & 100 & 135 & 140 & ns min & Chip Select to Write Setup Time \\
\hline \(\mathrm{t}_{\mathrm{CH}}\) & 0 & 0 & 0 & ns min & Chip Select to Write Hold Time \\
\hline \(\mathrm{t}_{\mathrm{w} R}\) & 100 & 135 & 140 & ns min & Write Pulse Width \\
\hline \(\mathrm{t}_{\mathrm{DS}}\) & 100 & 100 & 120 & ns min & Data Setup Time \\
\hline \(\mathrm{t}_{\text {DH }}\) & 20 & 20 & 20 & ns min & Data Hold Time \\
\hline
\end{tabular}

Specifications subject to change without notice.

\section*{ABSOLUTE MAXIMUM RATINGS*}
\begin{tabular}{|c|c|}
\hline \multicolumn{2}{|l|}{( \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) unless otherwise stated)} \\
\hline \(\mathrm{V}_{\text {DD }}\) to DGND & -0.3 V to +17 V \\
\hline \(\mathrm{V}_{\text {ss }}\) to DGND & +0.3 V to -17 V \\
\hline \(\mathrm{V}_{\text {REF }}\) to AGND & \(\pm 25 \mathrm{~V}\) \\
\hline \(\mathrm{V}_{\mathrm{RFB}}\) to AGND & \(\pm 25 \mathrm{~V}\) \\
\hline \(\mathrm{V}_{\text {RA }}\) to AGND & \(\pm 25 \mathrm{~V}\) \\
\hline \(\mathrm{V}_{\mathrm{RB}}\) to AGND & \(\pm 25 \mathrm{~V}\) \\
\hline \(\mathrm{V}_{\mathrm{RC}}\) to AGND & \(\pm 25 \mathrm{~V}\) \\
\hline \(V_{\text {Out }}\) to AGND \({ }^{1}\) & \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}, \mathrm{~V}_{\text {Ss }}-0.3 \mathrm{~V}\) \\
\hline AGND to DGND & . \(-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}\) \\
\hline \multicolumn{2}{|l|}{\multirow[b]{2}{*}{Power Dissipation (Any Package) \(\cdots \cdots-0.3{ }^{\text {a }}\) to \({ }^{\text {dD }}+0.3\)}} \\
\hline & \\
\hline To \(+75^{\circ} \mathrm{C}\) & 650 mW \\
\hline Derates above \(+75^{\circ} \mathrm{C}\) & . \(10 \mathrm{~mW} /{ }^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}

Operating Temperature Range
Commercial (J, K Versions) . . . . . . . . . . . . . . 0 to \(+70^{\circ} \mathrm{C}\)
Industrial (A, B Versions) . . . . . . . . . . . . \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
Extended (S, T Versions) . . . . . . . . . . . . \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
Storage Temperature Range . . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Lead Temperature (Soldering, 10 sec ) . . . . . . . . . . . \(+300^{\circ} \mathrm{C}\)
NOTE
\({ }^{1} V_{\text {Out }}\) may be shorted to AGND provided that the power dissipation of the package is not exceeded.
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect device reliability. Only one Absolute Maximum Rating may be applied at any one time.

\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are removed.


ORDERING GUIDE \({ }^{1}\)
\begin{tabular}{l|l|l|l}
\hline Model \(^{2}\) & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Relative \\
Accuracy
\end{tabular} & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD7845JN & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\mathrm{N}-24\) \\
AD7845KN & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\mathrm{N}-24\) \\
AD7845JP & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\mathrm{P}-28 \mathrm{~A}\) \\
AD7845KP & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\mathrm{P}-28 \mathrm{~A}\) \\
AD7845JR & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\mathrm{R}-24\) \\
AD7845KR & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\mathrm{R}-24\) \\
AD7845AQ & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\mathrm{Q}-24\) \\
AD7845BQ & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\mathrm{Q}-24\) \\
AD7845SQ/883B & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\mathrm{Q}-24\) \\
AD7845TQ/883B & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & \(\mathrm{Q}-24\) \\
AD7845SE/883B & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 \mathrm{LSB}\) & \(\mathrm{E}-28 \mathrm{~A}\) \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Analog Devices reserves the right to ship either ceramic (D-24A) or cerdip ( Q -24) hermetic packages.
\({ }^{2}\) To order MIL-STD-883, Class B processed parts, add /883B to part number.
\({ }^{3} \mathrm{E}=\) Leadless Ceramic Chip Carrier; \(\mathrm{N}=\) Plastic DIP; \(\mathrm{P}=\) Plastic Leaded Chip Carrier; \(\mathrm{Q}=\) Cerdip; \(\mathrm{R}=\) SOIC. For outline information see Package Information section.


\section*{NOTES}
1. AII INPUT SIGNAL RISE AND FALL TIMES MEASURED FROM \(10 \%\) to \(90 \%\) of \(+5 \mathrm{~V} . \mathrm{t}_{\mathrm{R}}=\mathrm{t}_{\mathrm{F}}=20 \mathrm{~ns}\).
2. TIMING MEASUREMENT REFERENCE LEVEL IS \(\frac{V_{\mathrm{IH}}+V_{\mathrm{IL}}}{2}\)

Figure 1. AD7845 Timing Diagram


\section*{TERMINOLOGY}

\section*{LEAST SIGNIFICANT BIT}

This is the analog weighting of 1 bit of the digital word in a DAC. For the AD7845, \(1 \mathrm{LSB}=\frac{V_{R E F}}{2^{12}}\).

\section*{RELATIVE ACCURACY}

Relative accuracy or endpoint nonlinearity is a measure of the maximum deviation from a straight line passing through the endpoints of the DAC transfer function. It is measured after adjusting for both endpoints (i.e., offset and gain error are adjusted out) and is normally expressed in least significant bits or as a percentage of full-scale range.

\section*{DIFFERENTIAL NONLINEARITY}

Differential nonlinearity is the difference between the measured change and the ideal 1 LSB change between any two adjacent codes. A specified differential nonlinearity of +1 LSB max over the operating temperature range ensures monotonicity.

\section*{GAIN ERROR}

Gain error is a measure of the output error between an ideal DAC and the actual device output with all 1s loaded after offset error has been adjusted out. Gain error is adjustable to zero with an external potentiometer. See Figure 13.

\section*{ZERO CODE OFFSET ERROR}

This is the error present at the device output with all 0 s loaded in the DAC. It is due to the op amp input offset voltage and bias current and the DAC leakage current.

\section*{TOTAL HARMONIC DISTORTION}

This is the ratio of the root-mean-square (rms) sum of the harmonics to the fundamental, expressed in dBs.

\section*{OUTPUT NOISE}

This is the noise due to the white noise of the DAC and the input noise of the amplifier.

\section*{DIGITAL-TO-ANALOG GLITCH IMPULSE}

This is the amount of charge injected from the digital inputs to the analog output when the inputs change state. This is normally specified as the area of the glitch in either pA-secs or nV -secs depending upon whether the glitch is measured as a current or voltage. The measurement takes place with \(\mathrm{V}_{\text {REF }}=\mathrm{AGND}\).

\section*{DIGITAL FEEDTHROUGH}

When the DAC is not selected (i.e., \(\overline{\mathrm{CS}}\) is high) high frequency logic activity on the device digital inputs is capacitively coupled through the device to show up as noise on the \(\mathrm{V}_{\text {Out }}\) pin. This noise is digital feedthrough.

\section*{MULTIPLYING FEEDTHROUGH ERROR}

This is ac error due to capacitive feedthrough from the \(\mathrm{V}_{\text {REF }}\) terminal to \(\mathrm{V}_{\text {OUT }}\) when the DAC is loaded with all Os.

\section*{OPEN-LOOP GAIN}

Open-loop gain is defined as the ratio of a change of output voltage to the voltage applied at the \(\mathrm{V}_{\text {REF }}\) pin with all 1 s loaded in the DAC. It is specified at dc.

\section*{UNITY GAIN SMALL SIGNAL BANDWIDTH}

This is the frequency at which the magnitude of the small signal voltage gain of the output amplifier is 3 dB below unity. The device is operated as a closed-loop unity gain inverter (i.e., DAC is loaded with all 1s).

\section*{OUTPUT RESISTANCE}

This is the effective output source resistance.

\section*{FULL POWER BANDWIDTH}

Full power bandwidth is specified as the maximum frequency, at unity closed-loop gain, for which a sinusoidal input signal will produce full output at rated load without exceeding a distortion level of \(3 \%\).

\section*{FEATURES}

\author{
16-Bit Monotonicity over Temperature \\ \(\pm 2\) LSBs Integral Linearity Error \\ Microprocessor Compatible with Readback Capability \\ Unipolar or Bipolar Output \\ Multiplying Capability \\ Low Power ( 100 mW typical)
}

\section*{GENERAL DESCRIPTION}

The AD7846 is a 16-bit DAC constructed with Analog Devices' \(\mathrm{LC}^{2}\) MOS process. It has \(\mathrm{V}_{\mathrm{REF}+}\) and \(\mathrm{V}_{\mathrm{REF}}-\) reference inputs and an on-chip output amplifier. These can be configured to give a unipolar output range ( 0 to \(+5 \mathrm{~V}, 0\) to +10 V ) or bipolar output ranges \(( \pm 5 \mathrm{~V}, \pm 10 \mathrm{~V})\).
The DAC uses a segmented architecture. The 4 MSBs in the DAC latch select one of the segments in a 16 -resistor string. Both taps of the segment are buffered by amplifiers and fed to a 12-bit DAC, which provides a further 12 bits of resolution. This architecture ensures 16 -bit monotonicity. Excellent integral linearity results from tight matching between the input offset voltages of the two buffer amplifiers.
In addition to the excellent accuracy specifications, the AD7846 also offers a comprehensive microprocessor interface. There are 16 data I/O pins, plus control lines ( \(\overline{\mathrm{CS}}, \mathrm{R} / \overline{\mathrm{W}}, \overline{\mathrm{LDAC}}\) and \(\overline{\mathrm{CLR}}) . \mathrm{R} \sqrt{\mathrm{W}}\) and \(\overline{\mathrm{CS}}\) allow writing to and reading from the I/O latch. This is the readback function which is useful in ATE applications. LDAC allows simultaneous updating of DACs in a multi-DAC system and the \(\overline{\mathrm{CLR}}\) line will reset the contents the DAC latch to \(00 \ldots 000\) or \(10 \ldots 000\) depending on the state of \(R \sqrt{\mathbf{W}}\). This means that the DAC output can be reset to 0 V in both the unipolar and bipolar configurations.
The AD7846 is available in 28 -pin plastic, ceramic, LCCC and PLCC packages.

FUNCTIONAL BLOCK DIAGRAM


\section*{PRODUCT HIGHLIGHTS}
1. 16-Bit Monotonicity

The guaranteed 16 -bit monotonicity over temperature makes the AD7846 ideal for closed-loop applications.
2. Readback

The ability to read back the DAC register contents minimizes software routines when the AD7846 is used in ATE systems.
3. Power Dissipation

Power dissipation of 100 mW makes the AD7846 the lowest power, high accuracy DAC on the market.

\footnotetext{
This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.
}
\(\left(V_{D 0}=+14.25 \mathrm{~V}\right.\) to \(+15.75 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=-14.25 \mathrm{~V}\) to \(-15.75 \mathrm{~V}, \mathrm{~V}_{\mathrm{cc}}=+4.75 \mathrm{~V}\) to
AD7846-SPECIFICATIONS \({ }^{1}\)
+5.25 V . \(\mathrm{V}_{\text {OUT }}\) loaded with \(2 \mathrm{k} \Omega\), 1000 pF to 0 VV . \(\mathrm{V}_{\text {REF }+}=+5 \mathrm{~V}\), \(\mathrm{R}_{\mathrm{IW}}\) connected to OV. All specifications \(\mathrm{T}_{\text {mIN }}\) to \(\mathrm{T}_{\text {max }}\) unless otherwise stated.)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Parameter & J, A Versions & K, B Versions & S Version \({ }^{\text {2 }}\) & Units & Test Conditions/Comments \\
\hline Resolution & 16 & 16 & 16 & Bits & \\
\hline UNIPOLAR OUTPUT & & & & & \(\mathrm{V}_{\text {REF- }}=0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=0 \mathrm{~V}\) to +10 V \\
\hline Relative Accuracy @ \(25^{\circ} \mathrm{C}\) & \(\pm 12\) & \(\pm 4\) & \(\pm 12\) & LSB typ & \(1 \mathrm{LSB}=153 \mu \mathrm{~V}\) \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & \(\pm 16\) & \(\pm 8\) & \(\pm 16\) & LSB max & \\
\hline Differential Nonlinearity Error & \(\pm 1\) & \(\pm 0.5\) & \(\pm 1\) & LSB max & All Grades Guaranteed Monotonic \\
\hline Gain Error @ \(25^{\circ} \mathrm{C}\) & \(\pm 12\) & \(\pm 6\) & \(\pm 12\) & LSB typ & \(\mathrm{V}_{\text {Out }}\) Load \(=10 \mathrm{M} \Omega\) \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & \(\pm 16\) & \(\pm 16\) & \(\pm 24\) & LSB max & \\
\hline Offset Error @ \(25^{\circ} \mathrm{C}\) & \(\pm 12\) & \(\pm 6\) & \(\pm 12\) & LSB typ & \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & \(\pm 16\) & \(\pm 16\) & \(\pm 24\) & LSB max & \\
\hline Gain TC \({ }^{3}\) & \(\pm 2\) & \(\pm 2\) & \(\pm 2\) & ppm FSR \({ }^{\circ} \mathrm{C}\) typ & \\
\hline Offset TC \({ }^{3}\) & \(\pm 2\) & \(\pm 2\) & \(\pm 2\) & ppm FSR \({ }^{\circ} \mathrm{C}\) typ & \\
\hline BIPOLAR OUTPUT & & & & & \(\mathrm{V}_{\text {REF- }}=-5 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-10 \mathrm{~V}\) to +10 V \\
\hline Relative Accuracy @ \(25^{\circ} \mathrm{C}\) & \(\pm 6\) & \(\pm 2\) & \(\pm 6\) & LSB typ & \(1 \mathrm{LSB}=305 \mu \mathrm{~V}\) \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & \(\pm 8\) & \(\pm 4\) & \(\pm 8\) & LSB max & \\
\hline Differential Nonlinearity Error & \(\pm 1\) & \(\pm 0.5\) & \(\pm 1\) & LSB max & All Grades Guaranteed Monotonic \\
\hline Gain Error @ \(25^{\circ} \mathrm{C}\) & \(\pm 6\) & \(\pm 4\) & \(\pm 6\) & LSB typ & \(\mathrm{V}_{\text {OUT }}\) Load \(=10 \mathrm{M} \Omega\) \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & \(\pm 16\) & \(\pm 16\) & \(\pm 16\) & LSB max & \\
\hline Offset Error @ \(25^{\circ} \mathrm{C}\) & \(\pm 6\) & \(\pm 4\) & \(\pm 6\) & LSB typ & Vout Load \(=10 \mathrm{M} \Omega\) \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & \(\pm 16\) & \(\pm 12\) & \(\pm 16\) & LSB max & \\
\hline Bipolar Zero Error @ \(25^{\circ} \mathrm{C}\) & \(\pm 6\) & \(\pm 4\) & \(\pm 6\) & LSB typ & \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & \(\pm 12\) & \(\pm 8\) & \(\pm 16\) & LSB max & \\
\hline Gain TC \({ }^{3}\) & \(\pm 2\) & \(\pm 2\) & \(\pm 2\) & ppm FSR \(/{ }^{\circ} \mathrm{C}\) typ & \\
\hline Offset TC \({ }^{3}\) & \(\pm 2\) & \(\pm 2\) & \(\pm 2\) & ppm FSR \({ }^{\circ} \mathrm{C}\) typ & , \\
\hline Bipolar Zero TC \({ }^{3}\) & \(\pm 2\) & \(\pm 2\) & \(\pm 2\) & ppm FSR \({ }^{\circ} \mathrm{C}\) typ & \\
\hline \begin{tabular}{l}
REFERENCE INPUT \\
Input Resistance
\end{tabular} & 20 & 20 & 20 & \(\mathrm{k} \Omega\) min & Resistance from \(\mathbf{V}_{\text {REF-- }}\) to \(\mathbf{V}_{\text {REF+ }}\) \\
\hline & 40 & 40 & & \(\mathrm{k} \Omega\) max & Typically \(30 \mathrm{k} \Omega\) \\
\hline \(\mathbf{V}_{\text {REF+ }}\) Range & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{ss}}+6 \text { to } \\
& \mathrm{V}_{\mathrm{DD}}-6
\end{aligned}
\] & \[
\begin{aligned}
& V_{s s}+6 \text { to } \\
& V_{D D}-6
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{ss}}+6 \text { to } \\
& \mathrm{V}_{\mathrm{DD}}-6
\end{aligned}
\] & Volts & \\
\hline \(\mathbf{V}_{\text {REF- }}\) Range & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{ss}}+6 \text { to } \\
& \mathrm{V}_{\mathrm{DD}}-6
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{ss}}+6 \text { to } \\
& \mathrm{V}_{\mathrm{DD}}-6
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{ss}}+6 \text { to } \\
& \mathrm{V}_{\mathrm{DD}}-6
\end{aligned}
\] & Volts & \\
\hline OUTPUT CHARACTERISTICS & & & & & \\
\hline Output Voltage Swing & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{ss}}+4 \text { to } \\
& \mathrm{V}_{\mathrm{DD}}-3
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{ss}}+4 \text { to } \\
& \mathrm{V}_{\mathrm{DD}}-3
\end{aligned}
\] & \[
\begin{aligned}
& V_{v_{s}+4 \text { to }}^{V_{D D}-3}
\end{aligned}
\] & \(V\) max & Cov \\
\hline Resistive Load & 2 & 2 & & \(\mathrm{k} \Omega\) min & To 0V \\
\hline Capacitive Load & 1000 & 1000 & 1000 & pF max & To 0V \\
\hline Output Resistance & 0.3 & 0.3 & 0.3 & \(\Omega\) typ & \\
\hline Short Circuit Current & \(\pm 25\) & \(\pm 25\) & \(\pm 25\) & mA typ & To 0V or Any Power Supply \\
\hline DIGITAL INPUTS & & & & & \\
\hline \(\mathbf{V}_{\text {IH }}\) (Input High Voltage) & 2.4 & 2.4 & 2.4 & \(\mathrm{V}_{\text {min }}\) & \\
\hline \(\mathrm{V}_{\text {IL }}\) (Input Low Voltage) & 0.8 & 0.8 & 0.8 & \(V\) max & \\
\hline \(\mathrm{I}_{\mathbf{1 N}}\) (Input Current) & \(\pm 10\) & \(\pm 10\) & \(\pm 10\) & \(\mu \mathrm{A}\) max & \\
\hline \(\mathrm{C}_{\text {IN }}\) (Input Capacitance) \({ }^{3}\) & 10 & 10 & 10 & pF max & \\
\hline DIGITAL OUTPUTS & & & & & \\
\hline \(\mathrm{V}_{\text {OL }}\) (Output Low Voltage) & 0.4 & 0.4 & 0.4 & Volts max & \(\mathrm{I}_{\text {SINK }}=1.6 \mathrm{~mA}\) \\
\hline \(\mathbf{V}_{\mathbf{O H}}\) (Output High Voltage) & 4.0 & 4.0 & 4.0 & Volts min & \(\mathrm{I}_{\text {SOURCE }}=400 \mu \mathrm{~A}\) \\
\hline Floating State Leakage Current & \(\pm 10\) & \(\pm 10\) & \(\pm 10\) & \(\mu \mathrm{A}\) max & DB0-DB15 \(=0\) to \(\mathrm{V}_{\mathrm{cc}}\) \\
\hline Floating State Output Capacitance \({ }^{3}\) & 10 & 10 & 10. & pF max & \\
\hline POWER REQUIREMENTS \({ }^{4}\) & & & & & \\
\hline \(\mathbf{V}_{\text {DD }}\) & +11.4/+15.75 & +11.4/+15.75 & +11.4/+15.75 & \(V \min / V \max\) & \\
\hline \(V_{\text {ss }}\) & -11.4/-15.75 & -11.4/-15.75 & -11.4/-15.75 & \(V \min / V_{\text {max }}\) & \\
\hline \(\mathrm{V}_{\mathbf{C c}}\) & +4.75/+5.25 & +4.75/+5.25 & +4.75/+5.25 & \(V \min / V_{\max }\) & \\
\hline \(\mathrm{I}_{\text {DD }}\) & 5 & 5 & 5 & mA max & Vout Unloaded \\
\hline \(\mathrm{I}_{\text {ss }}\) & 5 & 5 & 5 & mA max & \(\mathrm{V}_{\text {OUT }}\) Unloaded \\
\hline \(\mathrm{I}_{\text {cc }}\) & 1 & 1 & 1 & mA max & \\
\hline Power Supply Sensitivity \({ }^{5}\) & 1.5 & 1.5 & 2 & LSB/V max & \\
\hline Power Dissipation & 100 & 100 & 100 & mW typ & \(\mathrm{V}_{\text {OuT }}\) Unloaded \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Temperature Ranges as follows: J, K Versions: 0 to \(+70^{\circ} \mathrm{C}\);
A, B Versions: \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\); S Version: \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\).
\({ }^{2}\) Minimum load for S version is \(3 \mathrm{k} \Omega\).
\({ }^{3}\) Sample tested to ensure compliance.
\({ }^{4}\) AD7846 is functional with power supplies of \(\pm 12 \mathrm{~V}\). See Typical Performance Curves.
\({ }^{\text {S }}\) Sensitivity of Gain Error, Offset Error and Bipolar Zero Error to \(\mathbf{V}_{\text {DD }}, \mathbf{V}_{\text {ss }}\) variations.
Specifications subject to change without notice.

These characteristics are included for design guidance only and are not

\begin{tabular}{l|l|l|l|l}
\hline Parameter & \begin{tabular}{l}
\(\mathbf{T}_{\mathbf{A}}=\) \\
\(25^{\circ} \mathrm{C}\)
\end{tabular} & \begin{tabular}{l}
\(\mathbf{T}_{\mathbf{A}}=\) \\
\(\mathbf{T}_{\text {min }}\) to \(\mathbf{T}_{\text {max }}\)
\end{tabular} & Units & Test Conditions/Comments
\end{tabular}

\begin{tabular}{|c|c|c|c|c|c|}
\hline Parameter & Limit at
\[
\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}
\] & Limit at
\[
\begin{aligned}
& \mathrm{T}_{\mathrm{A}}=0 \text { to }+70^{\circ} \mathrm{C} \\
& \mathrm{~T}_{\mathrm{A}}=-25^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C}
\end{aligned}
\] & Limit at
\[
\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C} \text { to }+125^{\circ} \mathrm{C}
\] & Units & Test Conditions/Comments \\
\hline \(\mathrm{t}_{1}\) & 40 & 40 & 50 & ns min & \(\mathrm{R} \sqrt{\bar{W}}\) to \(\overline{\mathrm{CS}}\) Setup Time \\
\hline \(\mathrm{t}_{2}\) & 150 & 160 & 190 & ns min & \(\overline{\text { CS }}\) Pulse Width (Write Cycle) \\
\hline \(\mathrm{t}_{3}\) & 40 & 40 & 50 & ns \(\min\) & R/W to CS Hold Time \\
\hline \(\mathrm{t}_{4}\) & 110 & 110 & 120 & ns \(\min\) & Data Setup Time \\
\hline \(\mathrm{t}_{5}\) & 0 & 0 & 0 & ns \(\min\) & Data Hold Time \\
\hline \(t_{6}\) & 230 & 270 & 320 & ns \(\max\) & Data Access Time \\
\hline \(\mathrm{t}_{7}\) & 10 & 10 & 10 & ns min & Bus Relinquish Time \\
\hline & 80 & 90 & 90 & ns \(\max\) & \\
\hline \(\mathrm{t}_{8}\) & 20 & 20 & 20 & ns min & \(\overline{\text { CLR }}\) Setup Time \\
\hline t, & 150 & 150 & 150 & ns min & \(\overline{\text { CLR }}\) Pulse Width \\
\hline \(\mathrm{t}_{10}\) & 0 & 0 & 0 & ns min & \(\overline{\text { CLR }}\) Hold Time \\
\hline \(t_{11}\) & 80 & 100 & 100 & ns \(\min\) & LDAC Pulse Width \\
\hline \(\mathrm{t}_{12}\) & 240 & 280 & 330 & ns \(\min\) & \(\overline{\text { CS }}\) Pulse Width (Read Cycle) \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Timing specifications are sample tested at \(25^{\circ} \mathrm{C}\) to ensure compliance. All input control signals are specified with \(\mathrm{t}_{\mathbf{R}}=\mathrm{t}_{\mathbf{F}}=\mathbf{5} \mathbf{n s}\)
( \(10 \%\) to \(90 \%\) of +5 V ) and timed from a voltage level of 1.6 V .
\({ }^{2} \mathrm{t}_{6}\) is measured with the load circuits of Figure 1 and defined as the time required for an output to cross 0.8 V or 2.4 V .
\({ }^{3} \mathrm{t}_{7}\) is defined as the time required for an output to change 0.5 V when loaded with the circuits of Figure 2.
Specifications subject to change without notice.

a. High \(Z\) to \(V_{O H}\)

b. High \(Z\) to \(V_{O L}\)

Figure 1. Load Circuits for Access Time ( \(t_{6}\) )


b. \(V_{O L}\) to High \(Z\)


Figure 3. AD7846 Timing Diagram
a. \(V_{O H}\) to High \(Z\)

Figure 2. Load Circuits for Bus Relinquish Time ( \(t_{7}\) )

\section*{ABSOLUTE MAXIMUM RATINGS \({ }^{1}\)}

V \(_{\text {DD }}\) to DGND . . . . . . . . . . . . . . . . . . . . -0.3 V or +17 V
\(\mathrm{V}_{\mathrm{Cc}}\) to \(\mathrm{DGND}^{2}\)
. . . . . . . \(-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}\) or +7 V (Whichever Is Lower)
\(\mathrm{V}_{\text {ss }}\) to DGND . . . . . . . . . . . . . . . . . . . . . . +0.3 V to -17 V
V REF+ \(^{\text {to }}\) DGND. . . . . . . . . . . . . . . . . . . . . . . . . . . \(\pm 25 \mathrm{~V}\)
V \(_{\text {REF- }}\) to DGND. . . . . . . . . . . . . . . . . . . . . . . . . . . \(\pm 25 \mathrm{~V}\)
V \(_{\text {OUT }}\) to DGND \(^{3}\). . . . . . . . . . . . . . . . . . . . . . . . . . . . \(\pm 25 \mathrm{~V}\)
\(\mathrm{R}_{\mathrm{IN}}\) to DGND . . . . . . . . . . . . . . . . . . . . . . . . . . . . \(\pm 25 \mathrm{~V}\)
Digital Input Voltage to DGND . . . . . . . -0.3 V to \(\mathrm{V}_{\mathrm{cc}}+0.3 \mathrm{~V}\)
Digital Output Voltage to DGND . . . . . . -0.3 V to \(\mathrm{V}_{\mathrm{Cc}}+0.3 \mathrm{~V}\)
Power Dissipation (Any Package)
To \(+75^{\circ} \mathrm{C}\)
.1000 mW
Derates above \(+75^{\circ} \mathrm{C}\). . . . . . . . . . . . . . . . . . . . \(10 \mathrm{~mW} /{ }^{\circ} \mathrm{C}\)

\section*{Operating Temperature Range}

J, K Versions . . . . . . . . . . . . . . . . . . . . . . . . 0 to \(+70^{\circ} \mathrm{C}\)
A, B Versions. . . . . . . . . . . . . . . . . . . \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
S Version . . . . . . . . . . . . . . . . . . . . . . . \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
Storage Temperature Range . . . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Lead Temperature (Soldering) . . . . . . . . . . . . . . . . . \(+300^{\circ} \mathrm{C}\)
NOTES
\({ }^{1}\) Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect device reliability. Only one Absolute Maximum Rating may be applied at any one time.
\({ }^{2} \mathrm{~V}_{\mathrm{CC}}\) must not exceed \(\mathrm{V}_{\mathrm{DD}}\) by more than 0.3 V . If it is possible for this to happen during power supply sequencing, the following diode protection scheme will ensure protection.

\({ }^{3} \mathrm{~V}_{\text {OUT }}\) may be shorted to \(\mathrm{DGND}, \mathrm{V}_{\mathrm{DD}}, \mathrm{V}_{\mathrm{SS}}, \mathrm{V}_{\mathrm{CC}}\) provided that the power dissipation of the package is not exceeded.
\({ }^{*} \mathrm{Q}=\) Ceramic DIP; E \(=\) Leadless Ceramic Chip Carrier; \(\mathrm{N}=\) Plastic DIP; \(\mathbf{P}=\) Plastic Leaded Chip Carrier. For outline information see Package Information section.

\section*{ORDERING GUIDE}
\begin{tabular}{l|l|l|l}
\hline & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Relative \\
Accuracy
\end{tabular} & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD7846JN & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & \(\pm 16 \mathrm{LSB}\) & \(\mathrm{N}-28\) \\
AD7846KN & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & \(\pm 8 \mathrm{LSB}\) & \(\mathrm{N}-28\) \\
AD7846JP & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & \(\pm 16 \mathrm{LSB}\) & \(\mathrm{P}-28 \mathrm{~A}\) \\
AD7846KP & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & \(\pm 8 \mathrm{LSB}\) & \(\mathrm{P}-28 \mathrm{~A}\) \\
AD7846AQ & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 16 \mathrm{LSB}\) & \(\mathrm{Q}-28\) \\
AD7846BQ & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 8 \mathrm{LSB}\) & \(\mathrm{Q}-28\) \\
AD7846SQ/883B & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 16 \mathrm{LSB}\) & \(\mathrm{Q}-28\) \\
AD7846SE/883B & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 16 \mathrm{LSB}\) & \(\mathrm{E}-28 \mathrm{~A}\) \\
\hline
\end{tabular}

\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are removed.

\section*{PIN CONFIGURATIONS}


\section*{FEATURES}

\section*{14-Bit/16-Bit Multiplying DAC}

Guaranteed Monotonicity
Output Control on Power-Up and Power-Down
Internal or External Control
Versatile Serial Interface
DAC Clears to 0 V in Both Unipolar and Bipolar Output Ranges

\section*{APPLICATIONS}

Industrial Process Control PC Analog I/O Boards Instrumentation

\section*{GENERAL DESCRIPTION}

The AD7849 is a 14 -bit/16-bit serial input multiplying DAC. The DAC architecture ensures excellent differential linearity performance, and monotonicity is guaranteed to 14 bits for the A grade and to 16 bits for all other grades over the specified temperature ranges.
During power-up and power-down sequences (when the supply voltages are changing), the \(\mathrm{V}_{\text {OUT }}\) pin is clamped to 0 V via a low impedance path. To prevent the output of A 3 being shorted to 0 V during this time, transmission gate G 1 is also opened.
These conditions are maintained until the power supplies
stabilize and a valid word is written to the DAC register. At this time, G2 opens and G1 closes. Both transmission gates are also externally controllable via the Reset In ( \(\overline{\text { RST IN }}\) ) control input. For instance, if the RST IN input is driven from a battery supervisor chip, then on power-off or during a brown out, the The DAC must be reloaded, with RST IN high, to re-enable the output. Conversely, the on-chip voltage detector output ( \(\overline{\mathrm{RST}}\) \(\overline{\text { OUT }}\) ) is also available to the user to control other parts of the system.
The AD7849 has a versatile serial interface structure and can be controlled over three lines to facilitate opto-isolator applications.
SDOUT is the output of the on-chip shift register and can be used in a daisy-chain fashion to program devices in the multichannel system. The DCEN (Daisy Chain Enable) input controls this function.
The \(\overline{\mathrm{BIN} / C O M P}\) pin sets the DAC coding; with \(\overline{\mathrm{BIN}} / \mathrm{COMP}\) set to 0 , the coding is straight binary; and with it set to 1 , the coding is 2 s complement. This allows the user to reset the DAC to 0 V in both the unipolar and bipolar output ranges.
In addition, the output loop is closed externally allowing the user to accurately drive remote loads using force and sense techniques.

The part is available in a 20-pin DIP and 20-pin SOIC package.
FUNCTIONAL BLOCK DIAGRAM


This is a preliminary data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.
This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

AD7849-SPECIFICATIONS \({ }^{1}\)
\(\left(V_{D D}=+11.4 \mathrm{~V}\right.\) to \(+15.75 \mathrm{~V} ; \mathrm{V}_{\text {SS }}=-11.4 \mathrm{~V}\) to \(-15.75 \mathrm{~V} ; \mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}\) to \(5.25 \mathrm{~V} ; \mathrm{V}_{\text {OUT }}\) loaded with \(2 \mathrm{k} \Omega,{ }^{2} 200 \mathrm{pF}\) to \(\mathrm{O} \mathrm{V} ; \mathrm{V}_{\text {REF }}=+5 \mathrm{~V} ; \mathrm{R}_{\text {OFS }}\) connected to \(0 \mathrm{~V} ; \mathrm{T}_{A}=\mathrm{T}_{\text {MII }}\) to \(\mathrm{T}_{\text {max }}\), unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|}
\hline Parameter & \begin{tabular}{l}
A \\
Versions
\end{tabular} & \begin{tabular}{l}
\[
\mathbf{B}, \mathbf{T}
\] \\
Versions
\end{tabular} & \begin{tabular}{l}
C \\
Versions
\end{tabular} & Units & Test Conditions/Comments \\
\hline Resolution
UNIPOLAR OUTPUT & 14 & 16 & 16 & Bits & \begin{tabular}{l}
A Versions: 1 LSB \(=2\left(\mathrm{~V}_{\text {REF+ }}-\mathrm{V}_{\text {ReF- }}\right) / 2^{14}\) \\
B, C, T Versions: \(1 \mathrm{LSB}=2\left(\mathrm{~V}_{\text {REF+ }}-\mathrm{V}_{\text {Ref- }-} / 2^{16}\right.\) \\
\(\mathrm{V}_{\text {REF- }}=0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=0 \mathrm{~V}\) to +10 V
\end{tabular} \\
\hline Relative Accuracy & \(\pm 4\) & \(\pm 16\) & \(\pm 4\) & LSBs max &  \\
\hline Differential Nonlinearity & \(\pm 0.25\) & \(\pm 0.9\) & \(\pm 0.5\) & LSBs max & All Grades Guaranteed Monotonic Over Temperature \\
\hline Gain Error @ + \(25^{\circ} \mathrm{C}\) & \(\pm 3\) & \(\pm 12\) & \(\pm 6\) & LSBs max & \(\mathrm{V}_{\text {Out }}\) Load \(=10 \mathrm{M} \Omega\) \\
\hline \(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) & \(\pm 4\) & \(\pm 16\) & \(\pm 16\) & LSBs max & \\
\hline Offset Error @ +25 \({ }^{\circ} \mathrm{C}\) & \(\pm 3\) & \(\pm 12\) & \(\pm 6\) & LSBs max & \\
\hline \(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) & \(\pm 4\) & \(\pm 16\) & \(\pm 16\) & LSBs max & \\
\hline Gain \(\mathrm{TC}^{3}\). & \(\pm 2\) & \(\pm 2\) & \(\pm 2\) & ppm FSR \(/{ }^{\circ} \mathrm{C}\) typ & \\
\hline Offset TC \({ }^{3}\) & \(\pm 2\) & \(\pm 2\) & \(\pm 2\) & ppm FSR \(/{ }^{\circ} \mathrm{C}\) typ & \\
\hline BIPOLAR OUTPUT & & & & & \(\mathrm{V}_{\text {REF- }}=-5 \mathrm{~V}, \mathrm{~V}_{\text {OuT }}=-10 \mathrm{~V}\) to +10 V \\
\hline Relative Accuracy & \(\pm 2\) & \(\pm 8\) & \(\pm 2\) & LSBs max & \\
\hline Differential Nonlinearity & \(\pm 0.25\) & \(\pm 0.9\) & \(\pm 0.5\) & LSBs max & All Grades Guaranteed Monotonic Over Temperature \\
\hline Gain Error @ \(+25^{\circ} \mathrm{C}\) & \(\pm 1.5\) & \(\pm 6\) & \(\pm 4\) & LSBs max & \(\mathrm{V}_{\text {Out }}\) Load \(=10 \mathrm{M} \Omega\) \\
\hline \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) & \(\pm 3\) & \(\pm 12\) & \(\pm 8\) & LSBs max & \\
\hline Offset Error @ \(+25^{\circ} \mathrm{C}\) & \(\pm 1.5\) & \(\pm 6\) & \(\pm 4\) & LSBs max & \\
\hline \(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) & \(\pm 3\) & \(\pm 12\) & \(\pm 8\) & LSBs max & \\
\hline Bipolar Zero Error @ \(+25^{\circ} \mathrm{C}\) & \(\pm 1.5\) & \(\pm 6\) & \(\pm 4\) & LSBs max & - \\
\hline \(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) & \(\pm 3\) & \(\pm 12\) & \(\pm 8\) & LSBs max & - \\
\hline Gain TC \({ }^{3}\) & \(\pm 2\) & \(\pm 2\) & \(\pm 2\) & ppm FSR \(/{ }^{\circ} \mathrm{C}\) typ & \\
\hline Offset TC \({ }^{3}\) & \(\pm 2\) & \(\pm 2\) & \(\pm 2\) & ppm FSR \(/{ }^{\circ} \mathrm{C}\) typ & \\
\hline Bipolar Zero TC \({ }^{3}\) & \(\pm 2\) & \(\pm 2\) & \(\pm 2\) & ppm FSR \({ }^{\circ} \mathrm{C}\) typ & \\
\hline REFERENCE INPUT & & & & \# \({ }^{\text {a }}\) & - V \({ }^{\text {d }}\) \\
\hline Input Resistance & & & \[
\begin{aligned}
& 20 \\
& 40
\end{aligned}
\] & \(\mathrm{k} \Omega\) min
\(\mathrm{k} \Omega\) max & Resistance from \(\mathrm{V}_{\text {REF+ }}\) to \(\mathrm{V}_{\text {REF- }}\) Typically \(30 \mathrm{k} \Omega\) \\
\hline \(\mathrm{V}_{\text {REF+ }}\) Range & \(\mathrm{V}_{\text {Ss }}+6\) to & \(\mathrm{V}_{\text {Ss }}+6\) to & \(\mathrm{V}_{5 s}+6\) to & Volts & \\
\hline & \(\mathrm{V}_{\mathrm{DD}}-6\) & \(\mathrm{V}_{\mathrm{DD}}-6\) - & \(\mathrm{V}_{\mathrm{DD}}-6\) & - & \\
\hline \(\mathrm{V}_{\text {REF- }}\) Range & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{ss}}+6 \text { to } \\
& \mathrm{V}_{\mathrm{DD}}-6
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{ss}}+6 \text { to } \\
& \mathrm{V}_{\mathrm{DD}}-6
\end{aligned}
\] & \[
\begin{aligned}
& V_{S S}+6 t o \\
& V_{\text {bD }}-6
\end{aligned}
\] & & \\
\hline OUTPUT CHARACTERISTICS & & & - & \% & \\
\hline Output Voltage Swing & \(\mathrm{V}_{\text {ss }}+4\) to & \(\mathrm{V}_{\text {ss }}+4\) to & \(\mathrm{V}_{\text {Ss }}+4\) to & V max & \\
\hline & \(\mathrm{V}_{\mathrm{DD}}-3\) & \(\mathrm{V}_{\mathrm{DD}}-3\) & \(\mathrm{V}_{\mathrm{DD}}-3\) & & \\
\hline Resistive Load & 2 & 2 & 2 & \(\mathrm{k} \Omega\) min & To 0 V \\
\hline Capacitive Load & 1000 & 1000 & 1000 & pF max & To 0 V \\
\hline Output Resistance & 0.3 & 0.3 & 0.3 & \(\Omega\) typ & \\
\hline Short Circuit Current & \(\pm 25\) & \(\pm 25\) & \(\pm 25\) & mA typ & To 0 V or Any Power Supply \\
\hline DIGITAL INPUTS & & & & & \\
\hline \(\mathrm{V}_{\text {INH }}\), Input High Voltage & 2.4 & 2.4 & 2.4 & V min & \\
\hline \(\mathrm{V}_{\text {INL }}\), Input Low Voltage & 0.8 & 0.8 & 0.8 & V max & \\
\hline \(\mathrm{I}_{\mathrm{INH}}\), Input Current & \(\pm 10\) & \(\pm 10\) & \(\pm 10\) & \(\mu \mathrm{A}\) max & \\
\hline \(\mathrm{C}_{\text {IN }}\), Input Capacitance & 10 & 10 & 10 & pF max & \\
\hline DIGITAL OUTPUTS & & & & & \\
\hline \(\mathrm{V}_{\text {oL }}\) (Output Low Voltage) & 0.4 & 0.4 & 0.4 & Volts max & \(\mathrm{I}_{\mathrm{SINK}}=1.6 \mathrm{~mA}\) \\
\hline \(\mathrm{V}_{\text {OH }}\) (Output High Voltage) & 4.0 & 4.0 & 4.0 & Volts min & \(\mathrm{I}_{\text {SOURCE }}=400 \mu \mathrm{~A}\) \\
\hline Floating State Leakage Current & \(\pm 10\) & \(\pm 10\) & \(\pm 10\) & \(\mu \mathrm{A}\) max & DB0-DB15 \(=0 \mathrm{~V}\) to +5 V \\
\hline \begin{tabular}{l}
Floating State Output \\
Capacitance
\end{tabular} & 10 & 10 & 10 & \[
\mathrm{pF} \max
\] & \\
\hline POWER REQUIREMENTS & & & & & \\
\hline \(V_{\text {DD }}\) & +11.4/15.75 & +11.4/15.75 & +11.4/15.75 & V min/V max & \\
\hline \(\mathrm{V}_{\text {ss }}\) & -11.4/15.75 & -11.4/15.75 & -11.4/15.75 & V min/V max & \\
\hline \(\mathrm{V}_{\mathrm{cc}}\) & +4.75/+5.25 & +4.75/+5.25 & +4.75/+5.25 & V min/V max & \\
\hline \(\mathrm{I}_{\mathrm{DD}}\) & 5 & 5 & 5 & \(m A\) max & \(\mathrm{V}_{\text {out }}\) Unloaded \\
\hline \(\mathrm{I}_{\text {ss }}\) & 5 & 5 & 5 & mA max & \(\mathrm{V}_{\text {OUT }}\) Unloaded \\
\hline \(\mathrm{I}_{\text {CC }}\) & 1 & 1 & 1 & mA max & \\
\hline Power Supply Sensitivity \({ }^{4}\) & 0.4 & 1.5 & 1.5 & LSB/V max & \\
\hline Power Dissipation & 100 & 100 & 100 & mW typ & Vout Unloaded \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Temperature ranges: A, B, C Versions: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\); T Version: \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\).
\({ }^{2}\) Minimum load for \(T\) Version is \(3 \mathrm{k} \Omega\).
\({ }^{3}\) Sample tested to ensure compliance.
\({ }^{4}\) Sensitivity of gain error, offset error and bipolar zero error to \(\mathrm{V}_{\mathrm{DD}}, \mathrm{V}_{\mathrm{SS}}\) variations.
Specifications subject to change without notice.
This information applies to a product under development. Its characteristics and specifications are subject to change without notice.
Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

\section*{RESET SPECIFICATIONS}
(These specifications apply when the device goes into the Reset mode during a powerup or power-down sequence.)
\begin{tabular}{l|l|l|l}
\hline Parameter & All Versions & Units & Test Conditions/Comments \\
\hline \(\mathrm{V}_{\mathrm{A}}\), Low Threshold Voltage for \(\mathrm{V}_{\mathrm{DD}}, \mathrm{V}_{\mathrm{SS}}\) & 1 & 0 & Volt max \\
& This is the lower \(\mathrm{V}_{\mathrm{DD}} / \mathrm{V}_{\mathrm{SS}}\) threshold voltage for the reset \\
\(\mathrm{V}_{\mathrm{B}}\), High Threshold Voltage for \(\mathrm{V}_{\mathrm{DD}}, \mathrm{V}_{\mathrm{SS}}\) & 8.5 & 7.5 & Volts typ \\
& function. Above this, the reset is activated. \\
\(\mathrm{V}_{\mathrm{C}}\), Low Threshold Voltage for \(\mathrm{V}_{\mathrm{CC}}\) & 1 & This is the higher \(\mathrm{V}_{\mathrm{DD}} / \mathrm{V}_{\mathrm{SS}}\) threshold voltage for the reset \\
& Volts min & function. Below this, the reset is activated. Typically 8 volts. \\
\(\mathrm{V}_{\mathrm{D}}\), High Threshold Voltage for \(\mathrm{V}_{\mathrm{CC}}\) & 3.5 & Volt max & This is the lower threshold voltage for the reset function. \\
& 2.5 & Volts typ & Above this, the reset is activated. \\
\(\mathrm{G} 2 \mathrm{R}_{\mathrm{ON}}\) & Volts max & This is the higher \(\mathrm{V}_{\mathrm{CC}}\) threshold voltage for the reset function. \\
& Volts min & Below this, the reset is activated. Typically 3 volts. \\
& 1 & \(\mathrm{k} \Omega \max\) & On Resistance of \(\mathrm{G} 2 ; \mathrm{V}_{\mathrm{DD}}=2 \mathrm{~V} ; \mathrm{V}_{\mathrm{SS}}=-2 \mathrm{~V} ; \mathrm{I}_{\mathrm{G} 2}=1 \mathrm{~mA}\). \\
\hline
\end{tabular}

Specifications subject to change without notice.

\section*{AC PERFORMANCE CHARACTERISTICS (These characteristics are included for Design Guidance and are not}
subject to test. ( \(\mathrm{V}_{\text {REF }}=+5 \mathrm{~V} ; \mathrm{V}_{\mathrm{DO}}=+11.4 \mathrm{~V}\) to \(+15.75 \mathrm{~V} ; \mathrm{V}_{\mathrm{SS}}=-11.4 \mathrm{~V}\) to \(-15.75 \mathrm{~V} ; \mathrm{V}_{\mathrm{cc}}=4.75 \mathrm{~V}\) to \(5.25 \mathrm{~V} \mathrm{R}_{1 \mathrm{II}}\) connected to O .)


TIMING CHARACTERISTICS \(1,2\left(V_{D D}=+11.4 \mathrm{~V}\right.\) to \(+15.75 \mathrm{~V} ; \mathrm{V}_{S S}=-11.4 \mathrm{~V}\) to \(-15.75 \mathrm{~V} ; \mathrm{V}_{C C}=4.75 \mathrm{~V}\) to \(5.25 \mathrm{~V} ; \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}\) \(=200 \mathrm{pF}\). All Specifications \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) unless otherwise noted.)
\begin{tabular}{|c|c|c|c|c|}
\hline Parameter & \begin{tabular}{l}
Limit at \(+25^{\circ} \mathrm{C}\) \\
(All Versions)
\end{tabular} & Limit at \(\mathrm{T}_{\text {MIN }}, \mathrm{T}_{\text {MAX }}\) (All Versions) & Units & Conditions/Comments \\
\hline \(\mathrm{t}_{1}\) & 200 & 200 & ns min & SCLK Cycle Time \\
\hline \(\mathrm{t}_{2}\) & 50 & 50 & ns min & SYNC to SCLK Setup Time \\
\hline \(\mathrm{t}_{3}\) & 30 & 30 & ns min & SYNC to SCLK Hold Time \\
\hline \(\mathrm{t}_{4}\) & 60 & 60 & ns min & BIN/COMP to SCLK Setup Time \\
\hline \(\mathrm{t}_{5}\) & 10 & 10 & ns min & Data Setup Time \\
\hline \(\mathrm{t}_{6}\) & 100 & 100 & ns min & Data Hold Time \\
\hline \(\mathrm{t}_{7}{ }^{4}\) & 80 & 80 & ns max & SCLK Rising Edge to SDO Valid \\
\hline \(\mathrm{t}_{8}\) & 80 & 80 & ns min & LDAC, CLR Pulse Width \\
\hline \(\mathrm{t}_{\mathrm{r}}\) & 100 & 100 & \(\mu \mathrm{s}\) max & Digital Input Rise Time \\
\hline \(\mathrm{t}_{\text {f }}\) & 100 & 100 & \(\mu \mathrm{s}\) max & Digital Input Fall Time \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) All input signals are specified with \(\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%\) to \(90 \%\) of 5 V\()\) and timed from a voltage level of 1.6 V .
\({ }^{2}\) Guaranteed by characterization.
\({ }^{3}\) SCLK mark/space ratio range is \(40 / 60\) to \(60 / 40\).
\({ }^{4}\) SDO load capacitance is 50 pF .

\footnotetext{
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}

\section*{AD7849}
\begin{tabular}{|c|c|}
\hline \multicolumn{2}{|l|}{ABSOLUTE MAXIMUM RATINGS \({ }^{1}\)} \\
\hline \multicolumn{2}{|l|}{( \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) unless otherwise noted)} \\
\hline \multicolumn{2}{|l|}{\(\mathrm{V}_{\mathrm{DD}}\) to DGND . . . . . . . . . . . . . . . . . . . . . . - 0.3 V to +17. V} \\
\hline \multicolumn{2}{|l|}{} \\
\hline \multicolumn{2}{|l|}{V \({ }_{\text {Ss }}\) to DGND . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to -17 V} \\
\hline \multicolumn{2}{|l|}{\(\mathrm{V}_{\text {REF+ }}\) to DGND . . . . . . . . . . . . . . . . . . . . . . . . . . \(\pm 25 \mathrm{~V}\)} \\
\hline \multicolumn{2}{|l|}{\(\mathrm{V}_{\text {REF- }}\) to DGND . . . . . . . . . . . . . . . . . . . . . . . . . . . . . \(\pm 25\) V} \\
\hline \multicolumn{2}{|l|}{\(\mathrm{V}_{\text {OUt }}\) to DGND \({ }^{2}\). . . . . . . . . . . . . . . . . . . . . . . . . . . . \(\pm 25 \mathrm{~V}\)} \\
\hline \multicolumn{2}{|l|}{\(\mathrm{R}_{\mathrm{IN}}\) to DGND . . . . . . . . . . . . . . . . . . . . . . . . . . . . . \(\pm 25 \mathrm{~V}\)} \\
\hline \multicolumn{2}{|l|}{Digital Input Voltage to DGND ..... -0.3 V to \(\mathrm{V}_{\mathrm{CC}}+0.3 \mathrm{~V}\)} \\
\hline \multicolumn{2}{|l|}{Input Current to any Pin Except Supplies \({ }^{3} \ldots \ldots . . \ldots \ldots \pm 10 \mathrm{~mA}\)} \\
\hline \multicolumn{2}{|l|}{Operating Temperature Range} \\
\hline \multicolumn{2}{|l|}{\multirow[t]{2}{*}{\begin{tabular}{l}
Commercial/Industrial (B Versions). . . . . . . \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) \\
Extended (S Versions) . . . . . . . . . . . . . . . . . \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
\end{tabular}}} \\
\hline & \\
\hline \multicolumn{2}{|l|}{Storage Temperature Range . . . . . . . . . . . . \(65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)} \\
\hline Junction Temperature & \(+150^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}
DIP Package, Power Dissipation ..... 875 mW
\(\theta_{\mathrm{JA}}\) Thermal Impedance ..... \(75^{\circ} \mathrm{C} / \mathrm{W}\)
Lead Temperature (Soldering, 10 secs) ..... \(+260^{\circ} \mathrm{C}\)
SOIC Package, Power Dissipation ..... 875 mW
\(\theta_{\mathrm{JA}}\) Thermal Impedance ..... \(75^{\circ} \mathrm{C} / \mathrm{W}\)
Lead Temperature, Soldering
Vapor Phase (60 secs) . . . . . . . . . . . . . . . . . . . . . . . \(+215^{\circ} \mathrm{C}\)
Infrared (15 secs) ..... \(+220^{\circ} \mathrm{C}\)

\section*{NOTES}
\({ }^{1}\) Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
\({ }^{2} \mathrm{~V}_{\text {OUT }}\) may be shorted to \(\mathrm{DGND}, \mathrm{V}_{\mathrm{DD}}, \mathrm{V}_{\mathrm{SS}}\), provided that the power dissipation of the package is not exceeded.
\({ }^{3}\) Transient currents of up to 100 mA will not cause SCR latch-up.

\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD7849 feature proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality,
\begin{tabular}{l|l|l|l|l}
\multicolumn{5}{c}{ ORDERING GUIDE }
\end{tabular}
\({ }^{\star} \mathrm{N}=\) Plastic DIP; R = SOP (Small Outline Package); \(\mathrm{Q}=\) Cerdip. For outline information see Package Information section.

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Figure1. Timing Diagram (Stand-Alone Mode)

\section*{DIGITAL INTERFACE}

The AD7849 contains an input serial to parallel shift register and a DAC latch. A simplified diagram of the input loading circuitry is shown in Figure 2. Serial data on the SDIN input is loaded to the input register under control of DCEN, \(\overline{\text { SYNC }}\) and, SCLK. When a complete word is held in the shift register, it may then be loaded into the DAC latch under control of LDAC. Only the data in the DAC latch determines the analog output on the AD7849.

The DCEN (daisy-chain enable) input is used to select either a stand-alone mode or a daisy-chain mode. The loading format is slightly different depending on which mode is selected .

\section*{Serial Data Loading Format (Stand-Alone Mode)}

With DCEN at logic 0 the stand-alone mode is selected. In this mode a low \(\overline{\text { SYNC }}\) input provides the frame synchronization signal which tells the AD7849 that valid serial data on the SDIN input will be available for the next 16 falling edges of SCLK. An internal counter/decoder circuit provides a low gating signal so that only 16 data bits are clocked into the input shift register. After 16 SCLK pulses the internal gating signal goes inactive (high) thus locking out any further clock pulses. Therefore either a continuous clock or a burst clock source may be used to clock in the data.


The \(\overline{\text { SYNC }}\) input is taken high after the complete 16 -bit word is loaded in.
The AD7849B, AD7849C and AD7849T versions are 16-bit resolution DACs and have a straight 16-bit load format, with the MSB (DB15) being loaded first. The AD7849A is a 14 -bit DAC, but the loading structure is still 16-bit. The MSB (DB13) is loaded first and the final two bits of the 16-bit stream must be 0 s.

There are two ways in which the DAC latch and hence the ana\(\log\) output may be updated. The status of the \(\overline{\mathrm{LDAC}}\) input is examined after \(\overline{S Y N C}\) is taken low. Depending on its status, one of two update modes is selected.
If \(\overline{\mathrm{LDAC}}=0\), then the automatic update mode is selected. In this mode the DAC latch and analog output are updated automatically when the last bit in the serial data stream is clocked in. The update thus takes place on the sixteenth falling SCLK edge.
If \(\overline{\mathrm{LDAC}}=1\), then the automatic update is disabled. The DAC latch update and output update are now separate. The DAC latch is updated on the falling edge of \(\overline{\mathrm{LDAC}}\). However, the output update is delayed for a further \(2 \mu\) sy means of an internal track-and-hold amplifier in the output stage. This function results in lower digital-to-analog glitch impulse at the DAC output. Note that the \(\overline{\text { LDAC }}\) input must be taken back high again before the next data transfer is initiated.

Figure 2. Simplified Loading Structure

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

\section*{Serial Data Loading Format (Daisy-Chain Mode)}

By connecting DCEN high, the daisy-chain mode is enabled. This mode of operation is designed for multi-DAC systems where several AD7849s may be connected in cascade. In this mode, the internal gating circuitry on SCLK is disabled and a serial data output facility is enabled. The internal gating signal is permanently active (low) so that the SCLK signal is continuously applied to the input shift register when SYNC is low. The data is clocked into the register on each falling SCLK edge after SYNC going low. If more than 16 clock pulses are applied, the data ripples out of the shift register and appears on the SDOUT line. By connecting this line to the SDIN input on the next AD7849 in the chain, a multi-DAC interface may be constructed. Sixteen SCLK pulses are required for each DAC in the system. Therefore, the total number of clock cycles must equal \(16 \times \mathrm{N}\) where N is the total number of devices in the chain. When the serial transfer to all devices is complete, \(\overline{\text { SYNC }}\) is taken high. This prevents any further data being clocked into the input register.

A continuous SCLK source may be used if it can be arranged that SYNC is held low for the correct number of clock cycles. Alternatively, a burst clock containing the exact number of clock cycles may be used and SYNC taken high some time later.
When the transfer to all input registers is complete, a common \(\overline{\text { LDAC }}\) signal updates all DAC latches with the data in each input register. All analog outputs are therefore updated simultaneously, \(2 \mu \mathrm{~s}\) after the falling edge of \(\overline{\mathrm{LDAC}}\).

\section*{Clear Function ( \(\overline{\mathrm{CLR}}\) )}

The clear function bypasses the input shift register and loads the DAC Latch with all 0 s . It is activated by taking CLR low. In all ranges except the Offset Binary bipolar range ( -5 V to +5 V ) the output voltage is reset to 0 V . In the offset binary bipolar range the output is set to \(\mathrm{V}_{\text {REF-- }}\). This clear function is distinct and separate from the automatic power-on reset feature of the device.


Figure 3. Timing Diagram (Daisy-Chain Mode)

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\section*{AD7943/AD7945/AD7948}

\section*{FEATURES}

12-Bit Multiplying DACs
Guaranteed Specifications with +3.3 V/+5 V Supply 0.5 LSBs INL and DNL

Low Power: \(5 \mu \mathbf{W}\) typ
Fast Interface
40 ns Strobe Pulse Width (AD7943)
40 ns Write Pulse Width (AD7945, AD7948)
Low Glitch: 60 nV-s with Amplifier Connected Fast Settling: \(\mathbf{6 0 0}\) ns to \(\mathbf{0 . 0 1 \%}\) with AD843

\section*{APPLICATIONS}

Battery-Powered Instrumentation
Laptop Computers
Upgrades for All 754x Series DACs (5 V Designs)

\section*{GENERAL DESCRIPTION}

The AD7943, AD7945 and AD7948 are fast 12-bit multiplying DACs that operate from a single +5 V supply (Normal Mode) and a single +3.3 V to +5 V supply (Biased Mode). The AD7943 has a serial interface, the AD7945 has a 12-bit parallel interface, and the AD7948 has an 8-bit byte interface. They will replace the industry-standard AD7543, AD7545 and AD7548 in many applications, and they offer superior speed and power consumption performance.
The AD7943 is available in 16-pin DIP, 16-pin SOP (Small Outline Package) and 20-pin SSOP (Shrink Small Outline Package).
The AD7945 is available in 20-pin DIP, 20-pin SOP and 20-pin SSOP.
The AD7948 is available in 20-pin DIP, 20-pin SOP and 20-pin SSOP.



This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

\section*{AD7943/AD7945/AD7948-SPECIFICATIONS \({ }^{1}\)}

NORMAL MODE (AD7943: \(\mathrm{V}_{\mathrm{DD}}=+4.5 \mathrm{~V}\) to \(+5.5 \mathrm{~V} ; \mathrm{V}_{\text {10UT1 }}=\mathrm{V}_{\text {IOUT2 }}=\mathrm{AGND}=0 \mathrm{~V} ; \mathrm{V}_{\text {REF }}=+10 \mathrm{~V} ; \mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MII }}\) to \(\mathrm{T}_{\text {max }}\), unless otherwise noted. AD7945, AD7948: \(\mathrm{V}_{D 0}=+4.5 \mathrm{~V}\) to \(+5.5 \mathrm{~V} ; \mathrm{V}_{\text {IOUT1 }}=\mathrm{AGND}=0 \mathrm{~V} ; \mathrm{V}_{\text {REF }}=+10 \mathrm{~V} ; \mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\), unless otherwise noted.)
\begin{tabular}{|c|c|c|c|c|}
\hline Parameter & B Grades \({ }^{2}\) & T Grade \({ }^{2,3}\) & Units & Test Conditions/Comments \\
\hline \begin{tabular}{l}
ACCURACY \\
Resolution \\
Relative Accuracy \\
Differential Nonlinearity \\
Gain Error \\
\(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) \\
Gain Temperature Coefficient \({ }^{4}\) \\
Output Leakage Current \\
Iout1 \\
@ \(+25^{\circ} \mathrm{C}\) \\
\(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\)
\end{tabular} & \[
\begin{aligned}
& 12 \\
& \pm 0.5 \\
& \pm 0.5 \\
& \pm 2 \\
& 2 \\
& 5 \\
& \\
& 10 \\
& 100
\end{aligned}
\] & \[
\begin{aligned}
& 12 \\
& \pm 0.5 \\
& \pm 0.5 \\
& \\
& \pm 2 \\
& 2 \\
& 5
\end{aligned}
\] & \begin{tabular}{l}
Bits LSB max LSB max \\
LSB max ppm FSR \(/{ }^{\circ} \mathrm{C}\) typ ppm FSR \(/{ }^{\circ} \mathrm{C}\) max \\
nA max nA max
\end{tabular} & \begin{tabular}{l}
\[
1 \mathrm{LSB}=\mathrm{V}_{\mathrm{REF}} / 2^{12}=2.44 \mathrm{mV} \text { when } \mathrm{V}_{\mathrm{REF}}=10 \mathrm{~V}
\] \\
All Grades Guaranteed Monotonic over Temperature \\
See Terminology Section Typically 20 nA over Temperature
\end{tabular} \\
\hline \begin{tabular}{l}
REFERENCE INPUT \\
Input Resistance
\end{tabular} & \[
\begin{aligned}
& 6 \\
& 12
\end{aligned}
\] & \[
\begin{aligned}
& 6 \\
& 12
\end{aligned}
\] & \(\mathrm{k} \Omega\) min \(\mathrm{k} \Omega\) max & Typical Input Resistance \(=9 \mathrm{k} \boldsymbol{\Omega}\) \\
\hline \begin{tabular}{l}
DIGITAL INPUTS \\
\(\mathrm{V}_{\text {INH }}\), Input High Voltage \\
\(\mathrm{V}_{\text {INL }}\), Input Low Voltage \\
\(\mathrm{I}_{\text {INH }}\), Input Current \\
\(\mathrm{C}_{\text {IN }}\), Input Capacitance \({ }^{4}\)
\end{tabular} & \[
\begin{aligned}
& 2.4 \\
& 0.8 \\
& \pm 1 \\
& 10
\end{aligned}
\] & \[
\begin{gathered}
2.4 \\
0.8 \\
\pm 1 \\
10
\end{gathered}
\] & \begin{tabular}{l}
V min \\
V max \\
\(\mu \mathrm{A}\) max pF max
\end{tabular} & \\
\hline DIGITAL OUTPUT (AD7943 SRO) Output Low Voltage ( \(\mathrm{V}_{\mathrm{OL}}\) ) Output High Voltage ( \(\mathrm{V}_{\mathrm{OH}}\) ) & \[
\begin{aligned}
& 0.2 \\
& \mathrm{~V}_{\mathrm{DD}}-0.2
\end{aligned}
\] & \[
\begin{aligned}
& 0.2 \\
& \mathrm{~V}_{\mathrm{DD}}-0.2
\end{aligned}
\] & \begin{tabular}{l}
V max \\
V min
\end{tabular} & For 1 CMOS Load \\
\hline \begin{tabular}{l}
POWER REQUIREMENTS \\
\(V_{D D}\) Range \\
Power Supply Sensitivity \({ }^{4}\) \(\Delta\) Gain/ \(\Delta V_{D D}\) \\
\(\mathrm{I}_{\mathrm{DD}}\) (AD7943)
\end{tabular} & \[
\begin{aligned}
& 4.5 / 5.5 \\
& -75 \\
& 5
\end{aligned}
\] & \[
\begin{aligned}
& 4.5 / 5.5 \\
& -75 \\
& 5
\end{aligned}
\]
\[
5
\] & \begin{tabular}{l}
\(\mathrm{V} \min / V \max\) \\
dB typ \\
\(\mu \mathrm{A}\) max \\
\(\mu \mathrm{A}\) max
\end{tabular} & \begin{tabular}{l}
\(\mathrm{V}_{\mathrm{INH}}=\mathrm{V}_{\mathrm{DD}}-0.1 \mathrm{~V} \min , \mathrm{~V}_{\mathrm{INL}}=0.1 \mathrm{~V}\) max. SRO Open Circuit. No STB Signal. Typically \(1 \mu \mathrm{~A}\). Typically \(100 \mu \mathrm{~A}\) with a 1 MHz STB Frequency. At Input Levels of 0.8 V and 2.4 V , \(\mathrm{I}_{\mathrm{DD}}\) Is Typically 2.5 mA . \\
\(\mathrm{V}_{\mathrm{INH}}=\mathrm{V}_{\mathrm{DD}}-0.1 \mathrm{~V}\) min, \(\mathrm{V}_{\mathrm{INL}}=0.1 \mathrm{~V}\) max. \\
Typically \(1 \mu \mathrm{~A}\). At Input Levels of 0.8 V and \(2.4 \mathrm{~V}, \mathrm{I}_{\mathrm{DD}}\) Is Typically 2.5 mA .
\end{tabular} \\
\hline
\end{tabular}

NOTES
\({ }^{1}\) The AD7943, AD7945 and AD7948 are specified in the normal current mode configuration and in the biased current mode for single-supply applications.
Figures 15 and 16 are examples of normal mode operation.
\({ }^{2}\) Temperature ranges as follows: B Grades: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\); T Grade: \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\).
\({ }^{3}\) The T Grade applies to the AD7945 only.
\({ }^{4}\) Guaranteed by design.
Specifications subject to change without notice.
 wise noted. AD7945, AD7948: \(\mathrm{V}_{\text {DD }}=+3 \mathrm{~V}\) to +5.5 V ; \(\mathrm{V}_{\text {IOUT1 }}=\mathrm{AGND}=1.23 \mathrm{~V} ; \mathrm{V}_{\text {REF }}=+\mathrm{OV}\) to \(2.45 \mathrm{~V} ; \mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {mAx }}\), unless otherwise noted.)
\begin{tabular}{|c|c|c|c|}
\hline Parameter & A Grades \({ }^{2}\) & Units & Test Conditions/Comments \\
\hline \begin{tabular}{l}
ACCURACY \\
Resolution \\
Relative Accuracy Differential Nonlinearity \\
Gain Error @ + \(25^{\circ} \mathrm{C}\) \\
\(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) \\
Gain Temperature Coefficient \({ }^{3}\) \\
Output Leakage Current Iout1 \\
@ \(+25^{\circ} \mathrm{C}\) \\
\(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) \\
Input Resistance \\
@ \(\mathrm{I}_{\text {OUT2 }}\) Pin (AD7943) \\
@ AGND Pin (AD7945, AD7948)
\end{tabular} & \[
\begin{aligned}
& 12 \\
& \\
& \pm 1 \\
& \pm 0.9 \\
& \\
& \pm 3 \\
& \pm 4 \\
& 2 \\
& 5 \\
& \\
& 10 \\
& 100 \\
& 6 \\
& 6
\end{aligned}
\] & \begin{tabular}{l}
Bits \\
LSB max LSB max \\
LSB max LSB max ppm FSR \(/{ }^{\circ} \mathrm{C}\) typ ppm FSR \(/{ }^{\circ} \mathrm{C}\) max \\
nA max \\
\(n A \max\) \\
\(k \Omega\) min \\
\(\mathrm{k} \Omega\) min
\end{tabular} & \begin{tabular}{l}
\(1 \mathrm{LSB}=\left(\mathrm{V}_{\text {IOUT1 }}-\mathrm{V}_{\mathrm{REF}}\right) / 2^{12}=300 \mu \mathrm{~V}\) When \(\mathrm{V}_{\text {IOUT1 }}=1.23 \mathrm{~V}\) and \(\mathrm{V}_{\mathrm{REF}}=0 \mathrm{~V}\) \\
All Grades Guaranteed Monotonic over Temperature \\
See Terminology Section \\
Typically 20 nA over Temperature \\
This Varies with DAC Input Code
\end{tabular} \\
\hline \begin{tabular}{l}
DIGITAL INPUTS \\
\(\mathrm{V}_{\text {INH }}\), Input High Voltage @ \(\mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V}\) \\
\(\mathrm{V}_{\mathrm{INH}}\), Input High Voltage @ \(\mathrm{V}_{\mathrm{DD}}=+3.3 \mathrm{~V}\) \\
\(\mathrm{V}_{\text {INL }}\), Input Low Voltage @ \(\mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V}\) \\
\(\mathrm{V}_{\text {INL }}\), Input Low Voltage @ \(\mathrm{V}_{\mathrm{DD}}=+3.3 \mathrm{~V}\) \\
\(\mathrm{I}_{\text {INH }}\), Input Current \\
\(\mathrm{C}_{\text {IN }}\), Input Capacitance \({ }^{3}\)
\end{tabular} & \[
\begin{aligned}
& 2.4 \\
& 2.1 \\
& 0.8 \\
& 0.6 \\
& \pm 1 \\
& 10
\end{aligned}
\] & \begin{tabular}{l}
\(V\) min \\
\(V\) min \\
V max \\
V max \\
\(\mu \mathrm{A}\) max \\
pF max
\end{tabular} & \\
\hline \begin{tabular}{l}
DIGITAL OUTPUT (SRO) \\
Output Low Voltage ( \(\mathrm{V}_{\mathrm{OL}}\) ) \\
Output High Voltage ( \(\mathrm{V}_{\mathrm{OH}}\) )
\end{tabular} & \[
\begin{aligned}
& 0.2 \\
& \mathrm{~V}_{\mathrm{DD}}-0.2
\end{aligned}
\] & \begin{tabular}{l}
V max \\
\(V\) min
\end{tabular} & For 1 CMOS Load \\
\hline \begin{tabular}{l}
POWER REQUIREMENTS \\
\(V_{D D}\) Range \\
Power Supply Sensitivity \({ }^{3}\) \(\Delta\) Gain/ \(\Delta V_{\text {DD }}\) \(\mathrm{I}_{\mathrm{DD}}\) (AD7943) \\
\(\mathrm{I}_{\mathrm{DD}}\) (AD7945, AD7948)
\end{tabular} & \begin{tabular}{l}
\[
\begin{aligned}
& 3.0 / 5.5 \\
& -75 \\
& 5
\end{aligned}
\] \\
5
\end{tabular} & \begin{tabular}{l}
\(\mathrm{V} \min / \mathrm{V} \max\) \\
dB typ \\
\(\mu \mathrm{A}\) max \\
\(\mu \mathrm{A}\) max
\end{tabular} & \begin{tabular}{l}
\(\mathrm{V}_{\mathrm{INH}}=\mathrm{V}_{\mathrm{DD}}-0.1 \mathrm{~V} \min , \mathrm{~V}_{\mathrm{INL}}=0.1 \mathrm{~V}\) max. SRO Open Circuit; No STB Signal; Typically \(1 \mu \mathrm{~A}\). Typically \(100 \mu \mathrm{~A}\) with 1 MHz STB Frequency. \\
\(\mathrm{V}_{\mathrm{INH}}=\mathrm{V}_{\mathrm{DD}}-0.1 \mathrm{~V} \mathrm{~min}, \mathrm{~V}_{\mathrm{INL}}=0.1 \mathrm{~V}\) max. Typically \(1 \mu \mathrm{~A}\).
\end{tabular} \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) These specifications apply with the devices biased up at 1.23 V for single supply applications. The model numbering reflects this by means of a " -B " suffix (for example: AD7943AN-B). Figure 17 is an example of Biased Mode Operation.
\({ }^{2}\) Temperature ranges as follows: A Versions: \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\).
\({ }^{3}\) Guaranteed by design.
Specifications subject to change without notice.

\section*{AD7943/AD7945/AD7948}

AC PERFORMANCE CHARACTERISTICS
Normal Mode (AD7943: \(\mathrm{V}_{\mathrm{DD}}=+4.5 \mathrm{~V}\) to \(+5.5 \mathrm{~V} ; \mathrm{V}_{\text {10ur1 }}=\mathrm{V}_{\text {10urr } 2}=\mathrm{AGND}=0 \mathrm{~V}\). AD7945, AD7948: \(\mathrm{V}_{\mathrm{DD}}=+4.5 \mathrm{~V}\) to \(+5.5 \mathrm{~V} ; \mathrm{V}_{\text {IOUT1 }}=\mathrm{AGND}\) \(=0 \mathrm{~V} . \mathrm{V}_{\text {REF }}=6 \mathrm{~V} \mathrm{rms}\), 1 kHz sine wave; \(\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {max; }} \mathrm{DAC}\) output op amp is AD843; unless otherwise noted.) These characteristics are included for Design Guidance and are not subject to test.
\begin{tabular}{|c|c|c|c|c|}
\hline Parameter & B Grades & T Grade & Units & Test Conditions/Comments \\
\hline DYNAMIC PERFORMANCE Output Voltage Settling Time & 600 & 700 & ns typ & To \(0.01 \%\) of Full-Scale Range. \(\mathrm{V}_{\mathrm{REF}}=\) +10 V; DAC Latch Alternately Loaded with All 0s and All 1s \\
\hline Digital to Analog Glitch Impulse & 60 & 60 & nV-s typ & Measured with \(\mathrm{V}_{\mathrm{REF}}=0 \mathrm{~V}\). DAC Latch Alternately Loaded with All 0s and All 1s \\
\hline Multiplying Feedthrough Error & -75 & -75 & dB max & DAC Latch Loaded with All Os \\
\hline Output Capacitance & 60 & 60 & pF max & All 1s Loaded to DAC \\
\hline & 30 & 30 & pF max & All 0s Loaded to DAC \\
\hline Digital Feedthrough (AD7943) & 5 & 5 & nV-s typ & Feedthrough to the DAC Output with \(\overline{\mathrm{LD} 1}\), LD2 High and Alternate Loading of All 0s and All 1s into the Input Shift Register \\
\hline Digital Feedthrough (AD7945, AD7948) & 5 & 5 & nV-s typ & Feedthrough to the DAC Output with \(\overline{\mathrm{CS}}\) High and Alternate Loading of All Os and All 1s to the DAC Bus \\
\hline Total Harmonic Distortion & -83 & -83 & dB typ & \\
\hline \begin{tabular}{l}
Output Noise Spectral Density \\
@ 1 kHz
\end{tabular} & 35 & 35 & \(\mathrm{nV} / \sqrt{\mathrm{Hz}}\) typ & All 1s Loaded to DAC. \(\mathrm{V}_{\text {REF }}=0 \mathrm{~V}\). Output Op Amp Is OP07 \\
\hline
\end{tabular}

\section*{AC PERFORMANCE CHARACTERISTICS}

Biased Mode (aD7943: \(\mathrm{V}_{\text {DD }}=+3 \mathrm{~V}\) to \(+5.5 \mathrm{~V} ; \mathrm{V}_{\text {10ur1 }}=\mathrm{V}_{\text {IOUT2 }}=\mathrm{AGND}=1.23 \mathrm{~V}\). AD7945, AD7948: \(\mathrm{V}_{\mathrm{DD}}=+3 \mathrm{~V}\) to \(+5.5 \mathrm{~V} ; \mathrm{V}_{\text {10url }}=\mathrm{AGND}=\) 1.23 V . \(\mathrm{V}_{\text {REF }}=1 \mathrm{kHz}\), \(2.45 \mathrm{~V} \mathrm{p}-\mathrm{p}\), sine wave biased at 1.23 V ; DAC output op amp is AD820; \(\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {max; }}\) unless otherwise noted.) These characteristics are included for Design Guidance and are not subject to test.
\begin{tabular}{|c|c|c|c|}
\hline Parameter & A Grades & Units & Test Conditions/Comments \\
\hline \multicolumn{4}{|l|}{DYNAMIC PERFORMANCE} \\
\hline Output Voltage Settling Time & 5 & \(\mu \mathrm{styp}\) & To \(0.01 \%\) of Full-Scale Range. \(V_{\text {REF }}=0 \mathrm{~V}\) DAC Latch Alternately Loaded with All 0s and All 1s \\
\hline Digital to Analog Glitch Impulse & 60 & nV-s typ & \(\mathrm{V}_{\mathrm{REF}}=1.23 \mathrm{~V} . \mathrm{DAC}\) Register Alternately Loaded with All 0s and All 1s \\
\hline Multiplying Feedthrough Error & -75 & dB max & DAC Latch Loaded with All 0s \\
\hline Output Capacitance & 60 & pF max & All 1s Loaded to DAC \\
\hline & 30 & pF max & All 0s Loaded to DAC \\
\hline Digital Feedthrough & 5 & nV-s typ & Feedthrough to the DAC Output with \(\overline{\mathrm{LD} 1}, \overline{\mathrm{LD} 2}\) High and Alternate Loading of All Os and All 1s into the Input Shift Register \\
\hline Digital Feedthrough (AD7945, AD7948) & 5 & nV-s typ & Feedthrough to the DAC Output with \(\overline{\mathrm{CS}}\) High and Alternate Loading of All 0 s and All 1s to the DAC Bus \\
\hline Total Harmonic Distortion & -83 & dB typ & \\
\hline \begin{tabular}{l}
Output Noise Spectral Density \\
(a) \(\mathbf{i} \mathrm{kHz}\)
\end{tabular} & 25 & \(\mathrm{nV} / \sqrt{\mathrm{Hz}}\) typ & All 1 s Loaded to DAC. \(\mathrm{V}_{\mathrm{REF}}=1.23 \mathrm{~V}\) \\
\hline
\end{tabular}

\begin{tabular}{|c|c|c|c|c|}
\hline Parameter & Limit @
\[
V_{D D}=+3 \mathrm{~V} \text { to }+3.6 \mathrm{~V}
\] & Limit @
\[
V_{D D}=+4.5 \mathrm{~V} \text { to }+5.5 \mathrm{~V}
\] & Units & Description \\
\hline \(\mathrm{t}_{\mathrm{STB}}{ }^{2}\) & 60 & 40 & ns min & STB Pulse Width \\
\hline \(\mathrm{t}_{\mathrm{DS}}\) & 15 & 10 & ns min & Data Setup Time \\
\hline \(\mathrm{t}_{\mathrm{DH}}\) & 35 & 25 & ns min & Data Hold Time \\
\hline \(\mathrm{t}_{\text {SRI }}\) & 55 & 35 & ns min & SRI Data Pulse Width \\
\hline \(\mathrm{t}_{\text {LD }}\) & 55 & 35 & ns min & Load Pulse Width \\
\hline \(t_{\text {CLR }}\) & 55 & 35 & ns min & CLR Pulse Width \\
\hline \(\mathrm{t}_{\text {ASB }}\) & 0 & 0 & ns min & Min Time Between Strobing Input Shift Register and Loading DAC Register \\
\hline \(\mathrm{tsv}^{3}\) & 60 & 35 & ns max & STB Clocking Edge to SRO Data Valid Delay \\
\hline
\end{tabular}

NOTES
\({ }^{1}\) All input signals are specified with \(\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%\) to \(90 \%\) of 5 V\()\) and timed from a voltage level of 1.6 V . tr and tf should not exceed \(1 \mu \mathrm{~s}\) on any digital input. \({ }^{2}\) STB mark/space ratio range is \(60 / 40\) to \(40 / 60\).
\({ }^{3} \mathrm{t}_{\mathrm{sV}}\) is measured with the load circuit of Figure 2 and defined as the time required for the output to cross 0.8 V or 2.4 V .


Figure 1. AD7943 Timing Diagram


Figure 2. Load Circuit for Digital Output Timing Specifications

\section*{AD7943/AD7945/AD7948}

\section*{AD7945 TIMING SPECIFICATIONS \({ }^{1}\left(T_{A}=T_{\text {MIN }}\right.\) to \(T_{\text {MAX }}\), unless otherwise noted \()\)}
\begin{tabular}{l|l|l|l|l}
\hline & Limit @ & Limit @ & & \\
Parameter & \(\mathbf{V}_{\text {DD }}=+\mathbf{3 V}\) to +3.6 V & \(\mathbf{V}_{\text {DD }}=+\mathbf{+ 4 . 5} \mathbf{V}\) to \(+\mathbf{5 . 5} \mathbf{V}\) & Units & Description \\
\hline \(\mathrm{t}_{\mathrm{DS}}\) & 35 & 20 & ns min & Data Setup Time \\
\(\mathrm{t}_{\mathrm{DH}}\) & 10 & 10 & ns min & Data Hold Time \\
\(\mathrm{t}_{\mathrm{CS}}\) & 60 & 40 & ns min & Chip Select Setup Time \\
\(\mathrm{t}_{\mathrm{CH}}\) & 0 & 0 & ns min & Chip Select Hold Time \\
\(\mathrm{t}_{\mathrm{WR}}\) & 60 & 40 & ns min & Write Pulse Width \\
\hline
\end{tabular}

NOTE
\({ }^{1}\) All input signals are specified with \(\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%\) to \(90 \%\) of 5 V\()\) and timed from a voltage level of 1.6 V .


Figure 3. AD7945 Timing Diagram

\section*{}
\begin{tabular}{|c|c|c|c|c|}
\hline Parameter & Limit @
\[
V_{D D}=+3 \mathrm{~V} \text { to }+3.6 \mathrm{~V}
\] & Limit @
\[
V_{D D}=+4.5 \mathrm{~V} \text { to }+5.5 \mathrm{~V}
\] & Units & Description \\
\hline \(\mathrm{t}_{\mathrm{DS}}\) & 45 & 30 & ns min & Data Setup Time \\
\hline \(\mathrm{t}_{\mathrm{DH}}\) & 10 & 10 & ns min & Data Hold Time \\
\hline \(t_{\text {cw }}\) & 0 & 0 & ns min & \(\overline{\text { CSMSB }}\) or \(\overline{\text { CSLSB }}\) to \(\overline{\text { WR }}\) Setup Time \\
\hline \(\mathrm{t}_{\text {CWH }}\) & 0 & 0 & ns min & \(\overline{\text { CSMSB }}\) or CSLSB to \(\overline{\text { WR Hold Time }}\) \\
\hline \(\mathrm{t}_{\text {LWW }}\) & 0 & 0 & ns min & LDAC to WR Setup Time \\
\hline \(\mathrm{t}_{\text {LWH }}\) & 0 & 0 & ns min & \(\overline{\text { LDAC }}\) to WR Hold Time \\
\hline \(\mathrm{twr}^{\text {w }}\) & 60 & 40 & ns min & Write Pulse Width \\
\hline
\end{tabular}

NOTE
\({ }^{1}\) All input signals are specified with \(\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%\) to \(90 \%\) of 5 V\()\) and timed from a voltage level of 1.6 V .


Figure 4. AD7948 Timing Diagram
\begin{tabular}{|c|c|}
\hline \multicolumn{2}{|l|}{\begin{tabular}{l}
ABSOLUTE MAXIMUM RATINGS \({ }^{1}\) \\
( \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) unless otherwise noted)
\end{tabular}} \\
\hline \(V_{D D}\) to DGND & -0.3 V to +6 V \\
\hline \(\mathrm{I}_{\text {OUT1 }}\) to DGND & -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\) \\
\hline I \({ }_{\text {OUT2 }}\) to DGND . . . . . . . . . . . . . . . . . . & -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\) \\
\hline AGND to DGND . . . . . . . . . . . . . . . & -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\) \\
\hline Digital Input Voltage to DGND . . . . . & -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\) \\
\hline \(\mathrm{V}_{\mathrm{RFB}}, \mathrm{V}_{\mathrm{REF}}\) to DGND & \(\pm 15 \mathrm{~V}\) \\
\hline Input Current to Any Pin Except Supplies \({ }^{2}\) & \(\mathrm{s}^{2} \quad \ldots . . . . . \pm 10 \mathrm{~mA}\) \\
\hline Operating Temperature Range & \\
\hline Industrial (A, B Versions) & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) \\
\hline Extended (T Version) & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) \\
\hline Storage Temperature Range & \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\) \\
\hline Junction Temperature & \(+150^{\circ} \mathrm{C}\) \\
\hline DIP Package, Power Dissipation & 670 mW \\
\hline \(\theta_{\text {JA }}\) Thermal Impedance & \(116^{\circ} \mathrm{C} / \mathrm{W}\) \\
\hline Lead Temperature, Soldering, (10 sec) & \(+260^{\circ} \mathrm{C}\) \\
\hline
\end{tabular}
SOP Package, Power Dissipation . . . . . . . . . . . . . . . . 450 mW
\(\theta_{\mathrm{JA}}\) Thermal Impedance . . . . . . . . . . . . . . . . . . . . . \(75^{\circ} \mathrm{C} / \mathrm{W}\)
Lead Temperature, Soldering
Vapor Phase ( 60 sec ) . . . . . . . . . . . . . . . . . . . . . . \(+215^{\circ} \mathrm{C}\)
Infrared ( 15 sec ) . . . . . . . . . . . . . . . . . . . . . . . . . . . \(+220^{\circ} \mathrm{C}\)
SSOP Package, Power Dissipation . . . . . . . . . . . . . . . 875 mW
\(\theta_{\mathrm{JA}}\) Thermal Impedance . . . . . . . . . . . . . . . . . . . . . \(132^{\circ} \mathrm{C} / \mathrm{W}\)
Lead Temperature, Soldering
Vapor Phase ( 60 sec ) . . . . . . . . . . . . . . . . . . . . . . \(+215^{\circ} \mathrm{C}\)
Infrared (15 sec) . . . . . . . . . . . . . . . . . . . . . . . . . . . \(+220^{\circ} \mathrm{C}\)

\section*{NOTES}
\({ }^{1}\) Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
\({ }^{2}\) Transient currents of up to 100 mA will not cause SCR latch-up.

\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the devices feature proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

ORDERING GUIDE
\begin{tabular}{l|l|l|l|l}
\hline Model & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Linearity \\
Error (LSBs)
\end{tabular} & \begin{tabular}{l} 
Nominal \\
Supply Voltage
\end{tabular} & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD7943BN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 0.5\) & +5 V & \(\mathrm{~N}-16\) \\
AD7943BR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 0.5\) & +5 V & \(\mathrm{R}-16\) \\
AD7943BRS & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 0.5\) & +5 V & \(\mathrm{RS}-20\) \\
AD7943AN-B & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1\) & +3.3 V to +5 V & \(\mathrm{~N}-16\) \\
AD7943ARS-B & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1\) & +3.3 V to +5 V & \(\mathrm{RS}-20\) \\
AD7945BN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 0.5\) & +5 V & \(\mathrm{~N}-20\) \\
AD7945BR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 0.5\) & +5 V & \(\mathrm{R}-20\) \\
AD7945BRS & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 0.5\) & +5 V & \(\mathrm{RS}-20\) \\
AD7945AN-B & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1\) & +3.3 V to +5 V & \(\mathrm{~N}-20\) \\
AD7945ARS-B & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1\) & \(+3.3 \mathrm{~V} \mathrm{to}+5 \mathrm{~V}\) & \(\mathrm{RS}-20\) \\
AD7945TQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1\) & +5 V & \(\mathrm{Q}-20\) \\
AD7948BN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 0.5\) & +5 V & \(\mathrm{~N}-20\) \\
AD7948BR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 0.5\) & +5 V & \(\mathrm{R}-20\) \\
AD7948BRS & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 0.5\) & +5 V & \(\mathrm{RS}-20\) \\
AD7948AN-B & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1\) & +3.3 V to +5 V & \(\mathrm{~N}-20\) \\
AD7948ARS-B & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1\) & +3.3 V to +5 V & \(\mathrm{RS}-20\) \\
\hline
\end{tabular}

\footnotetext{
\({ }^{\star} \mathrm{N}=\) Plastic DIP; R = SOP (Small Outline Package); RS = SSOP (Shrink Small Outline Package); \(\mathrm{Q}=\) Cerdip. For outline information see Package Information section.
}

\section*{AD7943/AD7945/AD7948}

\section*{TERMINOLOGY}

\section*{Relative Accuracy}

Relative Accuracy or endpoint linearity is a measure of the maximum deviation from a straight line passing through the endpoints of the DAC transfer function. It is measured after adjusting for zero error and full-scale error and is normally expressed in Least Significant Bits or as a percentage of fullscale reading.

\section*{Differential Nonlinearity}

Differential nonlinearity is the difference between the measured change and the ideal 1 LSB change between any two adjacent codes. A specified differential nonlinearity of 1 LSB maximum ensures monotonicity.

\section*{Gain Error}

Gain Error is a measure of the output error between an ideal DAC and the actual device output. It is measured with all 1 s in the DAC after offset error has been adjusted out and is expressed in Least Significant Bits. Gain error is adjustable to zero with an external potentiometer.

\section*{Output Leakage Current}

Output leakage current is current which flows in the DAC ladder switches when these are turned off. For the \(\mathrm{I}_{\text {OUT1 }}\) terminal, it can be measured by loading all 0 s to the DAC and measuring the \(\mathrm{I}_{\text {OUT1 }}\) current. Minimum current will flow in the \(\mathrm{I}_{\mathrm{OUT} 2}\) line when the DAC is loaded with all 1 s .

\section*{Output Capacitance}

This is the capacitance from the \(I_{\text {OUT1 }}\) pin to AGND.

\section*{Output Voltage Settling Time}

This is the amount of time it takes for the output to settle to a specified level for a full-scale input change. For these devices, it is specified both with the AD843 as the output op amp in the normal current mode and with the AD820 in the biased current mode.

\section*{Digital to Analog Glitch Impulse}

This is the amount of charge injected into the analog output when the inputs change state. It is specified as the area of the glitch in nV-s. It is measured with the reference input connected to AGND and the digital inputs toggled between all 1 s and all 0s. As with Settling Time, it is specified with both the AD817 and the AD820.

\section*{AC Feedthrough Error}

This is the error due to capacitive feedthrough from the DAC reference input to the DAC \(\mathrm{I}_{\text {OUT } 1}\) terminal, when all 0 s are loaded in the DAC.

\section*{Digital Feedthrough}

When the device is not selected, high frequency logic activity on the device digital inputs is capacitively coupled through the device to show up as noise on the \(\mathrm{I}_{\text {OUT1 }}\) pin and subsequently on the op amp output. This noise is digital feedthrough.

PIN CONFIGURATIONS


DIP/SOP/SSOP


\section*{AD7943 PIN DESCRIPTION}
\begin{tabular}{|c|c|}
\hline Pin Mnemonic & Description \\
\hline \(\mathrm{I}_{\text {OUT } 1}\) & DAC current output terminal 1. \\
\hline \(\mathrm{I}_{\text {Out2 }}\) & DAC current output terminal 2. This should be connected to the AGND pin. \\
\hline AGND & This pin connects to the back gates of the current steering switches. In normal operation, it should be connected to the signal ground of the system. In biased single-supply operation it may be biased to some voltage between 0 V and the 1.23 V . See Figure 11 for more details. \\
\hline STB 1 & This is the Strobe 1 input. Data is clocked into the input shift register on the rising edge of this signal. \(\overline{\text { STB } 3}\) must be high. STB 2, STB 4 must be low. \\
\hline \(\overline{\text { LD1 }}, \overline{\text { LD2 }}\) & Active low inputs. When both of these are low, the DAC register is updated and the output will change to reflect this. \\
\hline SRI & Serial Data Input. Data on this line will be clocked into the input shift register on one of the Strobe inputs, when they are enabled. \\
\hline STB 2 & This is the Strobe 2 input. Data is clocked into the input shift register on the rising edge of this signal. \(\overline{\text { STB } 3}\) must be high. STB 1, STB 4 must be low. \\
\hline \(\overline{\text { STB } 3}\) & This is the Strobe 3 input. Data is clocked into the input shift register on the falling edge of this signal. STB 1, STB 2, STB 4, must be low. \\
\hline STB 4 & This is the Strobe 4 input. Data is clocked into the input shift register on the rising edge of this signal. \(\overline{\text { STB } 3}\) must be high. STB 1, STB 2 must be low. \\
\hline DGND & Digital Ground. \\
\hline \(\overline{\text { CLR }}\) & Asynchronous CLR input. When this input is taken low, all 0 s are loaded to the DAC latch. \\
\hline \(\mathrm{V}_{\mathrm{DD}}\) & Power supply input. This is nominally +5 V for Normal Mode Operation and +3.3 V to +5 V for Biased Mode Operation. \\
\hline \(\mathrm{V}_{\text {REF }}\) & DAC reference input. \\
\hline \(\underline{\mathrm{R}_{\text {FB }}}\) & DAC feedback resistor pin. \\
\hline
\end{tabular}

AD7945 PIN DESCRIPTION
\begin{tabular}{|c|c|}
\hline Pin Mnemonic & Description \\
\hline \(\mathrm{I}_{\text {OUT } 1}\) & DAC current output terminal 1. \\
\hline AGND & This pin connects to the back gates of the current steering switches. The DAC \(\mathrm{I}_{\mathrm{OUT} 2}\) terminal is also connected internally to this point. \\
\hline DGND & Digital Ground. \\
\hline DB11-DB0 & Digital Data Inputs. \\
\hline \(\overline{\mathrm{CS}}\) & Active Low, Chip Select Input. \\
\hline \(\overline{\mathrm{WR}}\) & Active Low, Write Input. \\
\hline \(\mathrm{V}_{\mathrm{DD}}\) & Power supply input. This is nominally +5 V for Normal Mode Operation and +3.3 V to +5 V for Biased Mode Operation. \\
\hline \(\mathrm{V}_{\text {REF }}\) & DAC reference input. \\
\hline \(\underline{\mathrm{R}_{\text {FB }}}\) & DAC feedback resistor pin. \\
\hline
\end{tabular}

\section*{AD7948 PIN DESCRIPTION}
\begin{tabular}{l|l}
\hline Pin Mnemonic & Description \\
\hline I OUT1 & \begin{tabular}{l} 
DAC current output terminal 1. Normally terminated at the virtual ground of output amplifier. \\
Analog Ground Pin. This pin connects to the back gates of the current steering switches. The DAC IOUT2 \\
terminal is also connected internally to this point. \\
DGND \\
DGigital Ground Pin. \\
Chip Select Most Significant Byte. Active Low Input. Used in combination with \(\overline{\text { WR }}\) to load \\
external data into the input register or in combination with \(\overline{\text { LDAC and WR to load external data into both input }}\) \\
and DAC registers.
\end{tabular} \\
\(\overline{\text { CSMSB }} \overline{\text { Data Format/Data Override. When this input is low, data in the DAC register is forced to one of two override }}\) \\
codes selected by CTRL. When the override signal is removed, the DAC output returns to reflect the value in \\
the DAC register. With DF/ \(\overline{\mathrm{DOR}}\) high, CTRL selects either a left or right justified input data format. For normal \\
operation, DF/DOR is held high. See Table I.
\end{tabular}

Table I. Truth Table for DF/DOR CTRL
\begin{tabular}{l|l|l}
\hline DF/DOR & CTRL & Function \\
\hline 0 & 0 & DAC Register Contents Overridden by All 0s \\
0 & 1 & DAC Register Contents Overridden by All 1s \\
1 & 0 & Left-Justified Input Data Selected \\
1 & 1 & Right-Justified Input Data Selected \\
\hline
\end{tabular}

CTRL
DB7-DB0
\(\overline{\text { LDAC }}\)
\(\overline{\text { CSLSB }}\)
\begin{tabular}{l|l}
\(\overline{\mathrm{WR}}\) & \begin{tabular}{l} 
Write input, active low. This active low signal, in combination with others is used in loading external data into \\
the AD7948 input register and in transferring data from the input register to the DAC register. \\
Power supply input. This is nominally +5 V for Normal Mode Operation and +3.3 V to +5 V for Biased Mode \\
Operation. \\
\(\mathrm{V}_{\mathrm{DD}}\)
\end{tabular} \\
\(\mathrm{V}_{\mathrm{REF}}\) & \begin{tabular}{l} 
DAC reference input. \\
\(\mathrm{R}_{\mathrm{FB}}\)
\end{tabular} \\
\hline
\end{tabular}

\section*{Typical Performance Curves}


Figure 5. Differential Nonlinearity Error vs. \(V_{\text {REF }}\) (Normal Mode)


Figure 6. Integral Nonlinearity Error vs. \(V_{\text {REF }}\) (Normal Mode)



Figure 8. Linearity Error vs. \(V_{\text {REF }}\) (Biased Mode)


Figure 9. All Codes Linearity in Biased Mode \(\left(V_{D D}=+3.3 \mathrm{~V}\right)\)


Figure 10. Total Harmonic Distortion vs. Frequency


Figure 11. Digital-to-Analog Glitch Impulse


Figure 12. Multiplying Frequency Response vs. Digital Code

\title{
AD7943/AD7945/AD7948
}

\section*{GENERAL DESCRIPTION}

\section*{D/A Section}

The AD7943, AD7945 and AD7948 are 12-bit current-output D/A converters. A simplified circuit diagram is shown in Figure 13. The DAC architecture is segmented. This means that the 2 MSBs of the 12 -bit data word are decoded to drive the three switches A, B and C. The remaining 10 bits of the data word drive the switches S 0 to S 9 in a standard inverting R-2R ladder configuration.

Each of the switches A to C steers \(1 / 4\) of the total reference current into either \(\mathrm{I}_{\mathrm{OUT} 1}\) or \(\mathrm{I}_{\mathrm{OUT} 2}\) with the remaining \(1 / 4\) of the total current passing through the R-2R section. Switches S9 to S0 steer binarily weighted currents into either \(\mathrm{I}_{\mathrm{OUT} 1}\) or \(\mathrm{I}_{\mathrm{OUT} 2}\). If \(\mathrm{I}_{\text {OUT1 }}\) and \(\mathrm{I}_{\text {OUT2 }}\) are kept at the same potential, a constant current flows in each ladder leg, regardless of digital input code. Thus, the input resistance seen at \(\mathrm{V}_{\text {REF }}\) is always constant. It is equal to \(\mathrm{R} / 2\). The \(\mathrm{V}_{\mathrm{REF}}\) input may be driven by any reference voltage or current, ac or dc that is within the Absolute Maximum Ratings.
The device provides access to the \(\mathrm{V}_{\mathrm{REF}}, \mathrm{R}_{\mathrm{FB}}\), and \(\mathrm{I}_{\mathrm{OUT} 1}\) terminals of the DAC. This makes the device extremely versatile and allows it to be configured in several different operating modes. Examples of these are shown in the following sections. The AD7943 also has a separate \(\mathrm{I}_{\text {OUT2 }}\) pin. In the AD7945 and AD7948 this is internally tied to AGND.
When an output amplifier is connected in the standard configuration of Figure 14, the output voltage is given by:
\[
V_{O U T}=-D \times V_{R E F}
\]
where D is the fractional representation of the digital word loaded to the DAC. D can be set from 0 to \(4095 / 4096\), since it has 12-bit resolution.


Figure 13. Simplified D/A Circuit Diagram

\section*{UNIPOLAR BINARY OPERATION}

\section*{(Two-Quadrant Multiplication)}

Figure 14 shows the standard unipolar binary connection diagram for the AD7943, AD7945 and AD7948. When \(\mathrm{V}_{\text {IN }}\) is an ac signal, the circuit performs two-quadrant multiplication. Resistors R1 and R2 allow the user to adjust the DAC gain error. With a specified gain error of 2 LSBs over temperature, these are not necessary in many applications. Circuit offset is due completely to the output amplifier offset. It can be removed by adjusting the amplifier offset voltage. Alternatively, choosing a low offset amplifier makes this unnecessary.
A1 should be chosen to suit the application. For example, the OP07 is ideal for very low bandwidth applications ( 10 kHz or

1. ONLY ONE DAC IS SHOWN FOR CLARITY.
2. DIGITAL INPUT CONNECTIONS ARE OMITTED.
3. C1 PHASE COMPENSATION (5-15pF) MAY BE REQUIRED WHEN USING HIGH SPEED AMPLIFIER.

Figure 14. Unipolar Binary Operation
lower) while the AD711 is suitable for medium bandwidth applications ( 200 kHz or lower). For high bandwidth applications of greater than 200 kHz , the AD843 and AD847 offer very fast settling times.
The code table for Figure 14 is shown in Table III.
Table III. Unipolar Binary Code
\begin{tabular}{l|l}
\hline \begin{tabular}{l} 
Digital Input \\
MSB LSB
\end{tabular} & \begin{tabular}{l} 
Analog Output \\
(VoUT as Shown in Figure 15)
\end{tabular} \\
\hline 111111111111 & \(-\mathrm{V}_{\mathrm{REF}}(4095 / 4096)\) \\
100000000001 & \(-\mathrm{V}_{\mathrm{REF}}(2049 / 4096)\) \\
100000000000 & \(-\mathrm{V}_{\mathrm{REF}}(2048 / 4096)\) \\
011111111111 & \(-\mathrm{V}_{\mathrm{REF}}(2047 / 4096)\) \\
000000000001 & \(-\mathrm{V}_{\mathrm{REF}}(1 / 4096)\) \\
000000000000 & \(-\mathrm{V}_{\mathrm{REF}}(0 / 4096)=0\) \\
\hline
\end{tabular}

NOTE
Nominal LSB size for the circuit of Figure 14 is given by: \(\mathrm{V}_{\mathrm{REF}}(1 / 4096)\).

\section*{AD7943/AD7945/AD7948}

\section*{BIPOLAR OPERATION}

\section*{(Four-Quadrant Multiplication)}

Figure 15 shows the standard connection diagram for bipolar operation of the AD7943, AD7945 and AD7948. The coding is offset binary as shown in Table IV. When \(\mathrm{V}_{\mathrm{IN}}\) is an ac signal, the circuit performs four-quadrant multiplication. Resistors R1 and R2 are for gain error adjustment and are not needed in many applications where the device gain error specifications are adequate. To maintain the gain error specifications, resistors R3, R4 and R5 should be ratio matched to \(0.01 \%\).


NOTES
1. ONLY ONE DAC IS SHOWN FOR CLARITY.
2. DIGITAL INPUT CONNECTIONS ARE OMITTED.
3. C1 PHASE COMPENSATION (5-15pF) MAY BE REQUIRED WHEN USING HIGH SPEED AMPLIFIER, A1.

Figure 15. Bipolar Operation (Four-Quadrant Multiplication)
Suitable dual amplifiers for use with Figure 15 are the OP270 (low noise, low bandwidth, 15 kHz ), the AD712 (medium bandwidth, 200 kHz ) or the AD827 (wide bandwidth, 1 MHz ).

Table IV. Bipolar (Offset Binary) Code
\begin{tabular}{l|l}
\hline \begin{tabular}{l} 
Table Digital Input \\
MSB \\
LSB
\end{tabular} & \begin{tabular}{l} 
Analog Output \\
\(\left(V_{\text {OUT }}\right.\) as Shown in Figure 16)
\end{tabular} \\
\hline 111111111111 & \(+\mathrm{V}_{\text {REF }}(2047 / 2048)\) \\
100000000001 & \(+\mathrm{V}_{\text {REF }}(1 / 2048)\) \\
100000000000 & \(+\mathrm{V}_{\text {REF }}(0 / 2048)=0\) \\
011111111111 & \(-\mathrm{V}_{\text {REF }}(1 / 2048)\) \\
000000000001 & \(-\mathrm{V}_{\text {REF }}(2047 / 2048)\) \\
000000000000 & \(-\mathrm{V}_{\text {REF }}(2048 / 2048)=-\mathrm{V}_{\text {REF }}\) \\
\hline
\end{tabular}

NOTE
Nominal LSB size for the circuit of Figure 15 is given by: \(\mathrm{V}_{\text {REF }}(1 / 2048)\).

\section*{SINGLE SUPPLY APPLICATIONS}

The "-B" versions of the devices are specified and tested for single supply applications. Figure 16 shows the recommended circuit for operation with a single +5 V to +3.3 V supply. The \(\mathrm{I}_{\text {OUT2 }}\) and AGND terminals are biased to 1.23 V . Thus, with 0 V applied to the \(\mathrm{V}_{\text {REF }}\) terminal, the output will go from 1.23 V (all 0s loaded to the DAC) to 2.46 V (all 1s loaded). With 2.45 V applied to the \(\mathrm{V}_{\text {REF }}\) terminal, the output will go from 1.23 V (all 0 s loaded) to 0.01 V (all 1s loaded). It is important when considering INL in a single-supply system to realize that most single-supply amplifiers cannot sink current and maintain zero volts at the output. In Figure 16, with \(\mathrm{V}_{\text {REF }}=2.45 \mathrm{~V}\) the required sink current is \(200 \mu \mathrm{~A}\). The minimum output voltage level is 10 mV . Op amps like the OP295 are capable of maintaining this level while sinking \(200 \mu \mathrm{~A}\).
Figure 16 shows the \(\mathrm{I}_{\text {OUT } 2}\) and AGND terminals being driven by an amplifier. This is to maintain the bias voltage at 1.23 V as the impedance seen looking into the \(\mathrm{I}_{\mathrm{OUT} 2}\) terminal changes. This impedance is code dependent and varies from infinity (all 0 s loaded in the DAC) to about \(6 \mathrm{k} \Omega\) minimum. The AD589 has a typical output resistance of \(0.6 \Omega\) and it can be used to drive the terminals directly. However, this will cause a typical linearity degradation of 0.2 LSB . If this is unacceptable then the buffer amplifier is necessary. Figure 9 shows the typical linearity performance of the AD7943/AD7945/AD7948 when used as in Figure 16 with \(\mathrm{V}_{\mathrm{DD}}\) set at +3.3 V and \(\mathrm{V}_{\mathrm{REF}}=0 \mathrm{~V}\).


Figure 16. Single Supply System

\section*{FEATURES}

Complete Dual 12-Bit DAC
No External Components
+5 V Single-Supply Operation \(\pm 10 \%\)
4.095 V Full Scale (1 mV/LSB)

Buffered Voltage Outputs
Low Power: 5 mW/DAC
Space Saving 1.5 mm Height SO-14 Package
APPLICATIONS
Digitally Controlled Calibration
Servo Controls
Process Control Equipment
Computer Peripherals
Portable Instrumentation
Cellular Base Stations Voltage Adjustment

\section*{GENERAL DESCRIPTION}

The AD8522 is a complete dual 12-bit, single-supply, voltage output DAC in a 14 -pin DIP, or SO-14 surface mount package. Fabricated in a CBCMOS process, features include a serial digital interface, onboard reference, and buffered voltage output. Ideal for +5 V -only systems, this monolithic device offers low cost and ease of use, and requires no external components to realize the full performance of the device.
The serial digital interface allows interfacing directly to numerous microcontroller ports, with a simple high speed, three-wire data, clock, and load strobe format. The 16-bit serial word contains the 12 -bit data word and DAC select address, which is decoded internally or can be decoded externally using \(\overline{\mathrm{LDA}}, \overline{\mathrm{LDB}}\)


Figure 1. Linearity Error vs. Digital Code \& Temperature
inputs. A serial data output allows the user to easily daisy-chain multiple devices in conjunction with a chip select input. A reset \(\overline{\mathrm{RS}}\) input sets the outputs to zero scale or midscale, as determined by the input MSB.
The output 4.095 V full scale is laser trimmed to maintain accuracy over the operating temperature range of the device, and gives the user an easy-to-use one-millivolt-per-bit resolution. A 2.5 V reference output is also available externally for other data acquisition circuitry, and for ratiometric applications. The output buffers are capable of driving \(\pm 5 \mathrm{~mA}\).
The AD8522 is available in the 14 -pin plastic DIP and low profile 1.5 mm SOIC-14 packages.

\section*{PACKAGE TYPES AVAILABLE}


This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

\section*{AD8522-SPECIFICATIONS}

ELECTRICAL CHARACTERISTICS \(\begin{aligned} & \left(@ V_{D D}=+5.0 \mathrm{~V} \pm 10 \%, R_{L}=N o \text { Load, }-40^{\circ} \mathrm{C} \leq \mathrm{T}_{A} \leq+85^{\circ} \mathrm{C} \text {, both DACs tested, unless }\right. \\ & \text { otherwe noted })\end{aligned}\)
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline Parameter & Symbol & Condition & Min & Typ & Max & Units \\
\hline \begin{tabular}{l}
STATIC PERFORMANCE \\
Resolution \({ }^{1}\) \\
Relative Accuracy Differential Nonlinearity Zero-Scale Error Full-Scale Voltage \({ }^{2}\) Full-Scale Tempco \({ }^{2,3}\)
\end{tabular} & \begin{tabular}{l}
N INL DNL \\
\(\mathrm{V}_{\text {ZSE }}\) \(V_{\text {FS }}\) \(\mathrm{TCV}_{\mathrm{FS}}\)
\end{tabular} & \begin{tabular}{l}
Monotonic \\
Data \(=000_{\mathrm{H}}\) \\
Data \(=\mathrm{FFF}_{\mathrm{H}}\)
\end{tabular} & \[
\begin{aligned}
& 12 \\
& -1.5 \\
& -1 \\
& 4.079
\end{aligned}
\] & \[
\begin{aligned}
& \pm 0.5 \\
& \pm 0.5 \\
& +0.5 \\
& 4.095 \\
& \pm 15
\end{aligned}
\] & \[
\begin{aligned}
& +1.5 \\
& +1 \\
& +3 \\
& 4.111
\end{aligned}
\] & Bits LSB LSB mV Volts \(\mathrm{ppm} /{ }^{\circ} \mathrm{C}\) \\
\hline MATCHING PERFORMANCE Linearity Matching Error & \(\Delta \mathrm{V}_{\mathrm{FS}} \mathrm{A} / \mathrm{B}\) & & & \(\pm 1\) & & LSB \\
\hline \begin{tabular}{l}
ANALOG OUTPUT \\
Output Current Load Regulation at Half-Scale Capacitive Load \({ }^{3}\)
\end{tabular} & \begin{tabular}{l}
\(\mathrm{I}_{\text {OUT }}\) \\
\(\mathrm{LD}_{\text {REG }}\) \\
\(\mathrm{C}_{\mathrm{L}}\)
\end{tabular} & \[
\begin{aligned}
& \text { Data }=800_{\mathrm{H}}, \Delta \mathrm{~V}_{\mathrm{OUT}} \leq 3 \mathrm{LSB} \\
& \mathrm{R}_{\mathrm{L}}=402 \Omega \text { to } \infty, \text { Data }=800_{\mathrm{H}} \\
& \text { No Oscillation }
\end{aligned}
\] & & \[
\begin{aligned}
& 1 \\
& 500
\end{aligned}
\] & \[
\begin{aligned}
& \pm 5 \\
& 3
\end{aligned}
\] & \begin{tabular}{l}
mA \\
LSB \\
pF
\end{tabular} \\
\hline \begin{tabular}{l}
REFERENCE OUTPUT \\
Output Voltage \\
Output Source Current \({ }^{4}\) \\
Line Rejection \\
Load Regulation
\end{tabular} & \begin{tabular}{l}
\(\mathrm{V}_{\text {REF }}\) \\
\(\mathrm{I}_{\text {REF }}\) \\
\(\mathrm{LN}_{\mathrm{REJ}}\) \\
\(L_{\text {REG }}\)
\end{tabular} & \[
\begin{aligned}
& \Delta \mathrm{V}_{\mathrm{REF}}<18 \mathrm{mV} \\
& \mathrm{I}_{\mathrm{REF}}=0 \text { to } 5 \mathrm{~mA}, \text { Data }=800_{\mathrm{H}}
\end{aligned}
\] & 2.484 & \[
\begin{aligned}
& 2.500 \\
& 0.025 \\
& 0.025
\end{aligned}
\] & \[
\begin{aligned}
& 2.516 \\
& 5 \\
& 0.08 \\
& 0.1 \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
V \\
mA \\
\%/V \\
\(\% / \mathrm{mA}\)
\end{tabular} \\
\hline \begin{tabular}{l}
LOGIC INPUTS \& OUTPUTS \\
Logic Input Low Voltage Logic Input High Voltage Input Leakage Current Input Capacitance \({ }^{3}\) Logic Output Voltage Low Logic Output Voltage High
\end{tabular} & \begin{tabular}{l}
\(\mathrm{V}_{\mathrm{IL}}\) \\
\(\mathrm{V}_{\mathrm{IH}}\) \\
\(\mathrm{I}_{\mathrm{IL}}\) \\
\(\mathrm{C}_{\mathrm{IL}}\) \\
\(\mathrm{V}_{\mathrm{OL}}\) \\
\(\mathrm{V}_{\mathrm{OH}}\)
\end{tabular} & \[
\begin{aligned}
& \mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA} \\
& \mathrm{I}_{\mathrm{OH}}=400 \mu \mathrm{~A}
\end{aligned}
\] & \[
2.4
\]
\[
3.5
\] & & \[
\begin{aligned}
& 0.8 \\
& 10 \\
& 10 \\
& 0.4
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{~V} \\
& \mu \mathrm{~A} \\
& \mathrm{pF} \\
& \mathrm{~V} \\
& \mathrm{~V}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
TIMING SPECIFICATIONS \({ }^{3,5}\) \\
Clock Width High \\
Clock Width Low \\
Load Pulse Width \\
Data Setup \\
Data Hold \\
Clear Pulse Width \\
Load Setup \\
Load Hold \\
Select \\
Deselect \\
Clock to SDO Propagation Delay
\end{tabular} & \begin{tabular}{l}
\(\mathrm{t}_{\mathrm{CH}}\) \(\mathrm{t}_{\mathrm{CL}}\) \\
\(t_{\text {LDW }}\). \\
\(t_{D S}\) \\
\(\mathrm{t}_{\mathrm{DH}}\) \\
\(t_{\text {CLRW }}\) \\
\(t_{\text {LD1 }}\) \\
\(\mathrm{t}_{\mathrm{LD} 2}\) \\
\(\mathrm{t}_{\mathrm{CSS}}\) \\
\({ }^{\mathrm{t}} \mathrm{CSH}\) \\
\(t_{P D}\)
\end{tabular} & \(\cdots\) & \[
\begin{aligned}
& 35 \\
& 35 \\
& 25 \\
& 10 \\
& 20 \\
& 20 \\
& 10 \\
& 10 \\
& 30 \\
& 30 \\
& 20
\end{aligned}
\] & \[
45
\] & 80 & \begin{tabular}{l}
ns \\
ns \\
ns \\
ns \\
ns \\
ns \\
ns \\
ns \\
ns \\
ns \\
ns
\end{tabular} \\
\hline \begin{tabular}{l}
AC CHARACTERISTICS \({ }^{3,5}\) \\
Voltage Output Settling Time \({ }^{6}\) Crosstalk \\
DAC Glitch Digital Feedthrough
\end{tabular} & \[
\begin{aligned}
& \mathrm{t}_{\mathrm{S}} \\
& \mathrm{C}_{\mathrm{T}} \\
& \mathrm{Q} \\
& \mathrm{D}_{\mathrm{FT}}
\end{aligned}
\] & \begin{tabular}{l}
To \(\pm 1\) LSB of Final Value \\
Signal Measured at DAC Output, \\
While Changing Opposite \(\overline{\mathrm{LDA}} / \overline{\mathrm{B}}\) \\
Half-Scale Transition \\
Signal Measured at DAC Output, \\
While Changing Data Without LDA \(/ \bar{B}\)
\end{tabular} & & \[
\begin{aligned}
& 16 \\
& 38 \\
& 13 \\
& 2
\end{aligned}
\] & & \begin{tabular}{l}
\(\mu \mathrm{s}\) \\
dB \\
nV s \\
nV s
\end{tabular} \\
\hline \begin{tabular}{l}
SUPPLY CHARACTERISTICS \\
Positive Supply Current \\
Power Dissipation \({ }^{7}\) \\
Power Supply Sensitivity
\end{tabular} & \begin{tabular}{l}
\(\mathrm{I}_{\mathrm{DD}}\) \\
\(\mathrm{P}_{\text {DISS }}\) \\
PSS \\
\hline
\end{tabular} & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{DD}}=5.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{IH}}=2.4 \mathrm{~V} \text { or } \mathrm{V}_{\mathrm{IL}}=0.8 \mathrm{~V} \\
& \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0 \mathrm{~V} \\
& \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{IH}}=2.4 \mathrm{~V} \text { or } \mathrm{V}_{\mathrm{IL}}=0.8 \mathrm{~V} \\
& \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0 \mathrm{~V} \\
& \Delta \mathrm{~V}_{\mathrm{DD}}= \pm 5 \%
\end{aligned}
\] & & \[
\begin{aligned}
& 3 \\
& 1 \\
& 15 \\
& 5 \\
& 0.002
\end{aligned}
\] & \[
\begin{aligned}
& 5 \\
& 2 \\
& 25 \\
& 10 \\
& 0.004
\end{aligned}
\] & \begin{tabular}{l}
mA \\
mA \\
mW \\
mW \\
\%/\%
\end{tabular} \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1} 1 \mathrm{LSB}=1 \mathrm{mV}\) for 0 V to +4.095 V output range.
\({ }^{2}\) Includes internal voltage reference error.
\({ }^{3}\) These parameters are guaranteed by design and not subject to production testing.
\({ }^{4}\) Very little sink current is available at the \(\mathrm{V}_{\mathrm{REF}}\) pin. Use external buffer if setting up a virtual ground.
\({ }^{5}\) All input control signals are specified with \(\mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=5 \mathrm{~ns}(10 \%\) to \(90 \%\) of \(+5 \mathrm{~V})\) and timed from a voltage level of 1.6 V .
\({ }^{6}\) The settling time specification does not apply for negative going transitions within the last 6 LSBs of ground. Some devices exhibit double the typical settling time in this 6 LSB region.
\({ }^{7}\) Power Dissipation is calculated \(I_{D D} \times 5 \mathrm{~V}\).
Specifications subject to change without notice.


Figure 2. Timing Diagram
SERIAL INPUT REGISTER DATA FORMAT
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multicolumn{16}{|l|}{Last First} \\
\hline D0 & D1 & D2 & D3 & D4 & D5 & D6 & D7 & D8 & D9 & D10 & D11 & D12 & D13 & D14 & D15 \\
\hline DB0 & DB1 & DB2 & DB3 & DB4 & DB5 & DB6 & DB7 & DB8 & DB9 & DB10 & DB11 & NC & A & B & Sf/Hd \\
\hline
\end{tabular}

Table I. Truth Table
\begin{tabular}{|c|c|c|c|c|c|}
\hline \multicolumn{3}{|l|}{Data Word} & \multicolumn{2}{|l|}{Ext Pins} & \multirow[b]{2}{*}{DAC Register} \\
\hline Sf/Hd & B & A & \(\overline{\text { LDA }}\) & \(\overline{\text { LDB }}\) & \\
\hline \multicolumn{6}{|l|}{Hardware Load:} \\
\hline L & X & X & \(\downarrow\) & \(\downarrow\) & Loads DACA + DACB with Data from SR \\
\hline L & X & X & \(\downarrow\) & H & Loads DACA with Data from SR \\
\hline L & X & X & H & \(\downarrow\) & Loads DACB with Data from SR \\
\hline L & X & X & H & H & No Load \\
\hline \multicolumn{6}{|l|}{Software Decode Load:} \\
\hline H & L & L & X & X & No Load \\
\hline H & H & L & \(\downarrow\) & \(\downarrow\) & Loads DACB with Data from SR, See Note 1 Below \\
\hline H & H & L & H & H & No Load \\
\hline H & L & H & \(\downarrow\) & \(\downarrow\) & Loads DACA with Data from SR, See Note 1 Below \\
\hline H & L & H & H & H & No Load \\
\hline H & H & H & \(\downarrow\) & \(\downarrow\) & Loads DACA + DACB with Data from SR, See 1 Note Below \\
\hline H & H & H & H & H & No Load \\
\hline
\end{tabular}

NOTES
\({ }^{1}\) In software mode \(\overline{\mathrm{LDA}}\) and \(\overline{\mathrm{LDB}}\) perform the same function. They can be tied together or the unused pin should be tied high.
\({ }^{2}\) External Pins \(\overline{\mathrm{LDA}}\) and \(\overline{\mathrm{LDB}}\) should always be high when shifting Data into the shift register.
\({ }^{3} \downarrow\) symbol denotes negative transition.


Figure 3. AC Timing SDO Pin Load Circuit
\begin{tabular}{|c|c|}
\hline Pin & Function \\
\hline SDI & Serial Data Input; input data loads directly into the shift register. \\
\hline CLK & Clock input, positive edge clocks data into shift register. \\
\hline \(\overline{\mathrm{CS}}\) & Chip Select, active low input. Prevents shift register loading when high. Does not affect \(\overline{\mathrm{LDA}}\) and \(\overline{\mathrm{LDB}}\) operation. \\
\hline \(\overline{\mathrm{LDA}} / \overline{\mathrm{B}}\) & Load DAC register strobes, active low. Transfers shift register data to DAC register. See truth table for operation. Software decode feature only requires one \(\overline{\mathrm{LD}}\) strobe. Tie \(\overline{\mathrm{LDA}}\) and \(\overline{\mathrm{LDB}}\) together or use one of them with the other pin tied high. \\
\hline SDO & Serial Data Output. Output of shift register, always active. \\
\hline \(\overline{\mathrm{RS}}\) & Resets DAC registers to condition determined by MSB pin. Active low input. \\
\hline MSB & Digital input: High presets DAC registers to half scale \(\left(800_{\mathrm{H}}\right)\); Low clears all registers to zero \(\left(000_{\mathrm{H}}\right)\), when \(\overline{\mathrm{RS}}\) is strobed to active low. \\
\hline \(\mathrm{V}_{\mathrm{DD}}\) & Positive +5 V power supply input. Tolerance \(\pm 10 \%\). \\
\hline AGND & Analog Ground Input. \\
\hline DGND & Digital Ground Input. \\
\hline \(\mathrm{V}_{\text {REF }}\) & Reference Voltage Output, 2.5 V nominal. \\
\hline \(\mathrm{V}_{\text {OUT AB }}\) & DAC A/B voltage outpûts, 4.095 V full scale, \(\pm 5 \mathrm{~mA}\) output. \\
\hline
\end{tabular}

\section*{PIN CONFIGURATION}

\section*{14-Pin Plastic DIP 14-Lead SO-14}


Table II. Truth Tables
\begin{tabular}{l|l|l}
\hline\(\overline{\mathbf{R S}}\) & \(\mathbf{M S B}\) & \begin{tabular}{l}
\multicolumn{1}{|c}{ DAC Register Preset } \\
Register Activity
\end{tabular} \\
\hline 0 & 0 & \begin{tabular}{l} 
Asynchronously Resets DAC Registers to Zero \\
Scale \\
Asynchronously Presets DAC Registers to \\
Half Scale \(\left(800_{H}\right)\)
\end{tabular} \\
0 & 1 & None
\end{tabular}

\section*{ABSOLUTE MAXIMUM RATINGS*}

VDD to DGND \& AGND . . . . . . . . . . . . . . . . . . . \(-0.3 \mathrm{~V},+7 \mathrm{~V}\)
Logic Inputs and Output to DGND .....-0.3 V, \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
\(V_{\text {OUT }}\) to AGND ............................ \(-0.3 \mathrm{~V}, \mathrm{~V}_{\text {DD }}+0.3 \mathrm{~V}\)
V \(_{\text {REF }}\) to AGND . . . . . . . . . . . . . . . . . . . . \(-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
AGND to DGND . . . . . . . . . . . . . . . . . . . . . . . . . \(-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}\)
\(\mathrm{I}_{\text {Out }}\) Short Circuit to GND or \(\mathrm{V}_{\mathrm{DD}}\). . . . . . . . . . . . . . . . . 50 mA
Package Power Dissipation ................. \(\left(T_{J} \max -T_{A}\right) / \theta_{J A}\)
Thermal Resistance, \(\theta_{\mathrm{JA}}\) 14-Pin Plastic DIP Package ( \(\mathrm{N}-14\) ) . . . . . . . . . . . . . \(83^{\circ} \mathrm{C} / \mathrm{W}\)
14-Lead SOIC Package (SO-14) . . . . . . . . . . . . . . . \(120^{\circ} \mathrm{C} / \mathrm{W}\)
Maximum Junction Temperature ( \(\mathrm{T}_{\mathrm{J}} \max\) ) . . . . . . . . . . \(150^{\circ} \mathrm{C}\)
Operating Temperature Range . . . . . . . . . . . . . \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
Storage Temperature Range . . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Lead Temperature (Soldering, 10 sec ) . . . . . . . . . . . . . \(+300^{\circ} \mathrm{C}\)
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability:

ORDERING GUIDE
\begin{tabular}{l|l|l|l}
\hline Model & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Package \\
Description
\end{tabular} & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD8522AN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 14-Pin P-DIP & N-14 \\
AD8522AR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 14-Lead SOIC & SO-14 \\
AD8522Chips & \(+25^{\circ} \mathrm{C}\) & Die & \\
\hline
\end{tabular}
*For outline information see Package Information section.
The AD8522 contains 1482 transistors.

\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD8522 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

\section*{AD8582}

\section*{FEATURES}

Complete Dual 12-Bit DAC

\section*{No External Components}

Single +5 Volt Operation
1 mV/Bit with 4.095 V Full Scale
True Voltage Output, \(\pm 5 \mathrm{~mA}\) Drive
Very Low Power: 5 mW

\section*{APPLICATIONS}

Digitally Controlled Calibration
Portable Equipment
Servo Controls
Process Control Equipment
PC Peripherals

\section*{GENERAL DESCRIPTION}

The AD8582 is a complete, parallel input, dual 12-bit, voltage output DAC designed to operate from a single +5 volt supply. Built using a CBCMOS process, this monolithic DAC offers the user low cost, and ease-of-use in +5 volt only systems.
Included on the chip, in addition to the DACs, are a rail-to-rail amplifier, latch and reference. The reference ( \(\mathrm{V}_{\mathrm{REF}}\) ) is trimmed to 2.5 volts output, and the on-chip amplifier gains up the DAC output to 4.095 volts full scale. The user needs only supply a +5 volt supply.
The AD8582 is coded natural binary. The op amp output swings from 0 volt to +4.095 volts for a one-millivolt-per-bit resolution, and is capable of driving \(\pm 5 \mathrm{~mA}\). Operation down to 4.3 V is possible with output load currents less than 1 mA .


Figure 1. Minimum Supply Voltage vs. Load

FUNCTIONAL BLOCK DIAGRAM


The high speed parallel data interface connects to the fastest processors without wait states. The double-buffered input structure allows the user to load the input registers one at a time, then a single load strobe tied to both LDA + LDB inputs will update both DAC outputs simultaneously. LDA and LDB can also be activated independently to immediately update their respective DAC registers. An address input decodes DAC A or DAC B when the chip select \(\overline{\mathrm{CS}}\) input is strobed. An asynchronous reset input sets the output to zero scale. The MSB bit can be used to establish a preset to midscale when the reset input is strobed.
The AD8582 is available in the 24 -pin plastic DIP and the surface mount SOIC-24. Each part is fully specified for operation over \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\), and the full \(+5 \mathrm{~V} \pm 5 \%\) power supply range.


Figure 2. Linearity Error vs. Digital Code and Temperature

\section*{AD8582-SPECIFICATIONS \\ }
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline Parameter & Symbol & Condition & Min & Typ & Max & Units \\
\hline \begin{tabular}{l}
STATIC PERFORMANCE \\
Resolution \\
Relative Accuracy \\
Differential Nonlinearity \\
Zero-Scale Error \\
Full-Scale Voltage \\
Full-Scale Tempco
\end{tabular} & \begin{tabular}{l}
N INL DNL \\
\(\mathrm{V}_{\text {ZSE }}\) \\
\(V_{\text {FS }}\) \(\mathrm{TCV}_{\mathrm{FS}}\)
\end{tabular} & \begin{tabular}{l}
Note 1 \\
Monotonic \\
Data \(=000_{\mathrm{H}}\) \\
Data \(=\mathrm{FFF}_{\mathrm{H}}\), \({ }^{2}\) \\
Notes 2 and 3
\end{tabular} & \[
\begin{aligned}
& 12 \\
& -2 \\
& -1 \\
& 4.079
\end{aligned}
\] & \[
\begin{aligned}
& \pm 3 / 4 \\
& \pm 3 / 4 \\
& +0.2 \\
& 4.095 \\
& \pm 16
\end{aligned}
\] & \[
\begin{aligned}
& +2 \\
& +1 \\
& +3 \\
& 4.111
\end{aligned}
\] & \begin{tabular}{l}
Bits \\
LSB \\
LSB \\
mV \\
V \\
\(\mathrm{ppm} /{ }^{\circ} \mathrm{C}\)
\end{tabular} \\
\hline MATCHING PERFORMANCE Linearity Matching Error & \(\Delta \mathrm{V}_{\mathrm{Fs}} \mathrm{A} / \mathrm{B}\) & & & \(\pm 1\) & & LSB \\
\hline \begin{tabular}{l}
REFERENCE OUTPUT \\
Output Voltage \\
Output Source Current \\
Line Rejection \\
Load Regulation
\end{tabular} & \[
\begin{aligned}
& \mathrm{V}_{\text {REF }} \\
& \mathrm{I}_{\text {REF }} \\
& \mathrm{LN}_{\text {REJ }} \\
& \mathrm{LD}_{\text {REG }}
\end{aligned}
\] & Note 4
\[
\mathrm{I}_{\mathrm{REF}}=0 \mathrm{~mA} \text { to } 5 \mathrm{~mA}
\] & 2.484 & 2.500 & \[
\begin{aligned}
& 2.516 \\
& -5 \\
& 0.08 \\
& 0.1
\end{aligned}
\] & \begin{tabular}{l}
V \\
mA \\
\%/V \\
\(\% / \mathrm{mA}\)
\end{tabular} \\
\hline \begin{tabular}{l}
ANALOG OUTPUT \\
Output Current Load Regulation at Half Scale Capacitive Load
\end{tabular} & \[
\begin{aligned}
& \mathrm{I}_{\mathrm{OUT}} \\
& \mathrm{LD}_{\text {REG }} \\
& \mathrm{C}_{\mathrm{L}}
\end{aligned}
\] & \[
\begin{aligned}
& \text { Data }=800_{\mathrm{H}} \\
& \mathrm{R}_{\mathrm{L}}=402 \Omega \text { to } \infty, \text { Data }=800_{\mathrm{H}} \\
& \text { No Oscillation }
\end{aligned}
\] & & \[
\begin{aligned}
& 1 \\
& 500
\end{aligned}
\] & \[
\pm 5
\] & \begin{tabular}{l}
mA \\
LSB \\
pF
\end{tabular} \\
\hline \begin{tabular}{l}
DYNAMIC CHARACTERISTICS \({ }^{3}\) \\
Crosstalk \\
Voltage Output Settling Times \({ }^{5}\) \\
Digital Feedthrough
\end{tabular} & \[
\begin{aligned}
& \mathrm{C}_{\mathrm{T}} \\
& \mathrm{t}_{\mathrm{S}} \\
& \mathrm{~F}_{\mathrm{T}}
\end{aligned}
\] & To \(\pm 1 \mathrm{LSB}\) of Final Value Signal Measured at DAC Output, While Changing Data ( \(\overline{\mathrm{LDA}}=\overline{\mathrm{LDB}}=" 1 "\) ) & & \[
\begin{aligned}
& >64 \\
& 16 \\
& 35
\end{aligned}
\] & & \begin{tabular}{l}
dB \\
\(\mu \mathrm{s}\) \\
nV s
\end{tabular} \\
\hline \begin{tabular}{l}
LOGIC INPUTS \\
Logic Input Low Voltage Logic Input High Voltage Input Leakage Current Input Capacitance
\end{tabular} & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{II}} \\
& \mathrm{~V}_{\mathrm{IH}} \\
& \mathrm{I}_{\mathrm{IL}} \\
& \mathrm{C}_{\mathrm{IL}}
\end{aligned}
\] & Note 3 & 2.4 & & \[
\begin{aligned}
& 0.8 \\
& 10 \\
& 10
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{~V} \\
& \mu \mathrm{~A} \\
& \mathrm{pF}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
TIMING SPECIFICATIONS \({ }^{3,6}\) \\
Chip Select Pulse Width \\
DAC Select Setup \\
DAC Select Hold \\
Data Setup \\
Data Hold \\
Load Setup \\
Load Hold \\
Load Pulse Width \\
Reset Pulse Width
\end{tabular} & \begin{tabular}{l}
\(\mathrm{t}_{\mathrm{csw}}\) \\
\(\mathrm{t}_{\mathrm{AS}}\) \\
\(\mathrm{t}_{\mathrm{AH}}\) \\
\(\mathrm{t}_{\mathrm{DS}}\) \\
\(\mathrm{t}_{\mathrm{DH}}\) \\
\(\mathrm{t}_{\mathrm{L}}\) \\
\(t_{\text {LH }}\) \\
\(\mathrm{t}_{\text {LDW }}\) \\
\(\mathrm{t}_{\text {RSW }}\)
\end{tabular} & & \[
\begin{aligned}
& 30 \\
& 30 \\
& 0 \\
& 30 \\
& 10 \\
& 20 \\
& 10 \\
& 20 \\
& 30
\end{aligned}
\] & & & \begin{tabular}{l}
ns \\
ns ns ns ns ns ns ns ns
\end{tabular} \\
\hline \begin{tabular}{l}
SUPPLY CHARACTERISTICS \\
Positive Supply Current \\
Power Dissipation \({ }^{7}\) \\
Power Supply Sensitivity
\end{tabular} & I \({ }_{\text {DD }}\)
\(\mathrm{P}_{\text {DISS }}\)
PSS & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{IH}}=2.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0.8 \mathrm{~V} \\
& \mathrm{~V}_{\mathrm{IL}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=+5 \mathrm{~V} \\
& \mathrm{~V}_{\mathrm{IH}}=2.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{LL}}=0.8 \mathrm{~V} \\
& \mathrm{~V}_{\mathrm{I}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=+5 \mathrm{~V} \\
& \Delta \mathrm{~V}_{\mathrm{DD}}= \pm 5 \%
\end{aligned}
\] & & \[
\begin{aligned}
& 4 \\
& 1 \\
& 20 \\
& 5 \\
& 0.002
\end{aligned}
\] & \[
\begin{aligned}
& 7 \\
& 2 \\
& 35 \\
& 10 \\
& 0.004
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{mA} \\
& \mathrm{~mA} \\
& \mathrm{~mW} \\
& \mathrm{~mW} \\
& \% \%
\end{aligned}
\] \\
\hline
\end{tabular}

\footnotetext{
NOTES
\({ }^{1} 1 \mathrm{LSB}=1 \mathrm{mV}\) for 0 V to +4.095 V output range.
\({ }^{2}\) Includes internal voltage reference error.
\({ }^{3}\) These parameters are guaranteed by design and not subject to production testing.
\({ }^{4}\) Very little sink current is available at the \(\mathrm{V}_{\text {REF }}\) pin. Use external buffer if setting up a virtual ground.
\({ }^{5}\) Settling time is not guaranteed for the first six codes 0 through 5.
\({ }^{6}\) All input control signals are specified with \(\mathrm{t}_{\mathrm{R}}=\mathrm{t}_{\mathrm{F}}=5 \mathrm{~ns}(10 \%\) to \(90 \%\) of \(+5 \mathrm{~V})\) and timed from a voltage level of 1.6 V .
\({ }^{7}\) Power dissipation is a calculated value \(\mathrm{I}_{\mathrm{DD}} \times 5 \mathrm{~V}\).
Specifications subject to change without notice.
}

\section*{ABSOLUTE MAXIMUM RATINGS*}
\(V_{D D}\) to DGND \& AGND . . . . . . . . . . . . . . . . . . . \(-0.3 \mathrm{~V},+7 \mathrm{~V}\)
Logic Inputs to DGND . . . . . . . . . . . . . . . \(-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
Vout to AGND . . . . . . . . . . . . . . . . . . . . \(-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
\(\mathrm{V}_{\text {REF }}\) to AGND . . . . . . . . . . . . . . . . . . . \(-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)
AGND to DGND . . . . . . . . . . . . . . . . . . . . . . . . . -0.3 V, VD \(_{\text {DD }}\)
Iout Short Circuit to GND . . . . . . . . . . . . . . . . . . . . . . . 50 mA
Package Power Dissipation . . . . . . . . . . . . . . . \(\left(\mathrm{T}_{\mathrm{J}} \max -\mathrm{T}_{\mathrm{A}}\right) / \theta_{\mathrm{JA}}\)
Thermal Resistance, \(\theta_{\mathrm{JA}}\) 24-Pin Plastic DIP Package ( \(\mathrm{N}-24\) ) . . . . . . . . . . . . . \(62^{\circ} \mathrm{C} / \mathrm{W}\)
24-Lead SOIC Package (SOL-24) . . . . . . . . . . . . . . \(73^{\circ} \mathrm{C} / \mathrm{W}\)
Maximum Junction Temperature ( \(\mathrm{T}_{\mathrm{J}} \max\) ) . . . . . . . . . . \(150^{\circ} \mathrm{C}\)
Operating Temperature Range . . . . . . . . . . . . \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
Storage Temperature Range . . . . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Lead Temperature (Soldering, 10 sec ) . . . . . . . . . . . . \(+300^{\circ} \mathrm{C}\)
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.


Timing Diagram

\section*{ORDERING INFORMATION \({ }^{\mathbf{1}}\)}
\begin{tabular}{l|l|l|l}
\hline Model & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Package \\
Description
\end{tabular} & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD8582AN & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 24-Pin Plastic DIP & N-24 \\
AD8582AR & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 24-Lead SOIC & SOL-24 \\
AD8582Chips & \(+25^{\circ} \mathrm{C}\) & Die & \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) For die specifications contact your local Analog Devices sales office. The
AD8582 contains 1270 transistors.
\({ }^{2}\) For outline information see Package Information section.

\section*{PIN DESCRIPTION}
\begin{tabular}{|c|c|c|}
\hline Pin No. & Name & Description \\
\hline 1, 24 & \begin{tabular}{l}
\(V_{\text {OUTA }}\) \\
\(V_{\text {OUTB }}\)
\end{tabular} & Voltage outputs from the DACs. Fixed output voltage range of 0 V to 4.095 V with \(1 \mathrm{mV} / \mathrm{LSB}\). An internal temperature stabilized reference maintains a fixed full-scale voltage independent of time, temperature and power supply variations. \\
\hline 2 & AGND & Analog Ground. Ground reference for the internal bandgap reference voltage, the DAC, and the output buffer. \\
\hline 3 & DGND & Digital ground for input logic. \\
\hline 4, 21 & \[
\overline{\overline{\mathrm{LDA}},}
\] & Load DAC register strobes. Transfers input register data to the DAC registers. Active low inputs, Level sensitive latch. May be connected together to doublebuffer load DAC registers. \\
\hline 5 & MSB & Digital Input: High presets DAC registers to half scale \(\left(800_{\mathrm{H}}\right)\), Low clears DAC registers to zero \(\left(000_{\mathrm{H}}\right)\) upon \(\overline{\mathrm{RST}}\) assertion. \\
\hline 6 & \(\overline{\mathrm{RST}}\) & Active low digital input that clears the DAC register to zero, setting the DAC to minimum scale when \(M S B\) pin \(=0\), or half-scale when MSB pin \(=1\). \\
\hline 7-18 & \(\mathrm{DB}_{0-11}\) & Twelve Binary Data Bit Inputs. DB11 is the MSB and DB0 is the LSB. \\
\hline 19 & \(\overline{\mathrm{CS}}\) & Chip Select. Active low input. \\
\hline 20 & \(\overline{\mathrm{A}} / \mathrm{B}\) & Select DAC A \(=0\) or DAC B \(=1\). \\
\hline 22 & \(\mathrm{V}_{\mathrm{DD}}\) & Positive Supply. Nominal value \(+5 \mathrm{~V}, \pm 5 \%\). \\
\hline 23 & \(\mathrm{V}_{\text {REF }}\) & Nominal 2.5 V reference output voltage. This node must be buffered if required to drive external loads. \\
\hline
\end{tabular}

PIN CONFIGURATIONS

N-24
24-Pin Plastic DIP


SOL-24
24-Pin SOIC


\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD8582 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


Table I. Control Logic Truth Table
\begin{tabular}{llllll|l|l}
\hline\(\overline{\mathbf{C S}}\) & \(\overline{\mathbf{A} / B}\) & \(\overline{\text { LDA }}\) & \(\overline{\text { LDB }}\) & \(\overline{\mathbf{R S T}}\) & MSB & Input Register & DAC Register \\
\hline L & L & H & H & H & X & Write to A & Latched \\
L & H & H & H & H & X & Write to B & Latched \\
L & L & L & H & H & X & Write to A & A Transparent \\
L & H & H & L & H & X & Write to B & B Transparent \\
H & X & L & L & H & X & Latched & A \& B Transparent \\
H & X & A & A & H & X & Latched & Latched \\
X & X & X & X & L & L & Reset to Zero Scale & Reset to Zero Scale \\
X & X & X & X & L & H & Reset to Midscale & Reset to Midscale \\
H & X & X & X & \(\wedge\) & X & Latch Reset Value & Latch Reset Value \\
\hline
\end{tabular}
\({ }^{\wedge}\) Denotes positive edge triggered.

\section*{OPERATION}

The AD8582 is a complete, ready-to-use dual 12-bit digital-toanalog converter. Only one +5 V power supply is necessary for operation. It contains two voltage-switched, 12-bit, lasertrimmed digital-to-analog converters, a curvature-corrected bandgap reference, rail-to-rail output op amps, input registers, and DAC registers. The parallel data interface consists of twelve data bits, DB0-DB11, an address select pin \(\overline{\mathrm{A}} / \mathrm{B}\), two load strobe pins ( \(\overline{\mathrm{LDA}}, \overline{\mathrm{LDB}}\) ) and an active low \(\overline{\mathrm{CS}}\) strobe. In addition an asynchronous \(\overline{\mathrm{RST}}\) pin will set all DAC register bits to zero causing the \(V_{\text {OUt }}\) to become zero volts, or to midscale for trimming applications when the MSB pin is programmed to Logic 1. This function is useful for power on reset or system failure recovery to a known state.

\section*{D/A CONVERTER SECTION}

The internal DAC is a 12-bit voltage-mode device with an output that swings from AGND potential to the 2.5 volt internal bandgap voltage. It uses a laser trimmed R-2R ladder which is switched by N channel MOSFETs. The output voltage of the DAC has a constant resistance independent of digital input code. The DAC output (not available to the user) is internally connected to the rail-to-rail output op amp.

\section*{AMPLIFIER SECTION}

The internal DAC's output is buffered by a low power consumption precision amplifier. This low power amplifier contains a differential PNP pair input stage which provides low offset voltage and low noise, as well as the ability to amplify the zeroscale DAC output voltages. The rail-to-rail amplifier is configured in a gain of \(1.6384(=4.095 \mathrm{~V} / 2.5 \mathrm{~V})\) in order to set the 4.095 volt full-scale output ( \(1 \mathrm{mV} / \mathrm{LSB}\) ). See Figure 3 for an equivalent circuit schematic of the analog section.
The op amp has a \(16 \mu\) s typical settling time to \(0.01 \%\). There are slight differences in settling time for negative slewing signals versus positive. See the oscilloscope photos in the Typical Performances section of this data sheet.


Figure 3. Equivalent Schematic of Analog Portion

\section*{OUTPUT SECTION}

The rail-to-rail output stage of this amplifier has been designed to provide precision performance while operating near either power supply. Figure 4 shows an equivalent output schematic of the rail-to-rail amplifier with its N channel pull-down FETs that will pull an output load directly to GND. The output sourcing current is provided by a \(P\) channel pull-up device that can supply GND terminated loads, especially important at the \(-5 \%\) supply tolerance value of 4.75 volts.


Figure 4. Equivalent Analog Output Circuit

Figures 5 and 6 in the typical performance characteristics section provide information on output swing performance near ground and full-scale as a function of load. In addition to resistive load driving capability, the amplifier has also been carefully designed and characterized for up to 500 pF capacitive load driving capability.

\section*{REFERENCE SECTION}

The internal 2.5 V curvature-corrected bandgap voltage reference is laser trimmed for both initial accuracy and low temperature coefficient. The voltage generated by the reference is available at the \(\mathrm{V}_{\text {REF }}\) pin. Since \(\mathrm{V}_{\text {REF }}\) is not intended to drive external loads, it must be buffered. The equivalent emitter follower output circuit of the \(\mathrm{V}_{\text {REF }}\) pin is shown in Figure 3.
Bypassing the \(\mathrm{V}_{\text {REF }}\) pin will improve noise performance; however, bypassing is not required for proper operation. Figure 8 shows broadband noise performance.

\section*{POWER SUPPLY}

The very low power consumption of the AD8582 is a direct result of a circuit design optimizing use of the CBCMOS process. By using the low power characteristics of the CMOS for the logic, and the low noise, tight matching of the complementary bipolar transistors good analog accuracy is achieved.
For power-consumption sensitive applications it is important to note that the internal power consumption of the AD8582 is strongly dependent on the actual logic-input voltage levels present on the DB0-DB11, \(\overline{\mathrm{CS}}, \overline{\mathrm{A}} / \mathrm{B}, \mathrm{MSB}, \overline{\mathrm{LDA}}, \overline{\mathrm{LDB}}\) and \(\overline{\mathrm{RST}}\) pins. Since these inputs are standard CMOS logic structures they contribute static power dissipation dependent on the actual driving logic \(\mathrm{V}_{\mathrm{OH}}\) and \(\mathrm{V}_{\mathrm{OL}}\) voltage levels. The graph in Figure 9 shows the effect on total AD8582 supply current as a function of the actual value of input logic voltage. Consequently, for optimum dissipation use of CMOS logic versus TTL provides minimal dissipation in the static state. \(\mathrm{A} \mathrm{V}_{\mathrm{INL}}=\) 0 V on the DB0-11 pins provides the lowest standby dissipation of 1 mA typical with \(\mathrm{a}+5 \mathrm{~V}\) power supply.
As with any analog system, it is recommended that the AD8582 power supply be bypassed on the same PC card that contains the chip. Figure 10 shows the power supply rejection versus frequency performance. This should be taken into account when using higher frequency switched-mode power supplies with ripple frequencies of 100 kHz and higher.

One advantage of the rail-to-rail output amplifiers used in the AD8582 is the wide range of usable supply voltage. The part is fully specified and tested over temperature for operation from +4.75 V to +5.25 V . If reduced linearity and source current capability near full scale can be tolerated, operation of the AD8582 is possible down to +4.3 volts. The minimum operating supply voltage versus load current plot, in Figure 1, provides information for operation below \(\mathrm{V}_{\mathrm{DD}}=+4.75 \mathrm{~V}\).

\section*{TIMING AND CONTROL}

The input registers are level triggered and acquire data from the data bus during the time period when \(\overline{\mathrm{CS}}\) is low. The input register selected is determined by the \(\bar{A} / B\) select pin, see Table I. for a complete description. When \(\overline{\mathrm{CS}}\) goes high, the data is latched into the register and held until CS returns low. The minimum time required for the data to be present on the bus before \(\overline{\mathrm{CS}}\) returns high is called the data setup time ( \(\mathrm{t}_{\mathrm{DS}}\) ) as seen in Timing Diagram. The data hold time ( \(\mathrm{t}_{\mathrm{DH}}\) ) is the amount of time that the data has to remain on the bus after \(\overline{\mathrm{CS}}\) goes high. The high speed timing offered by the AD8582 provides for direct interface with no wait states in all but the fastest microprocessors.
The data from the input registers is transferred to the DAC registers by the active low \(\overline{\mathrm{LDA}}\) and \(\overline{\mathrm{LDB}}\) pins. If these inputs are tied together, a single logic input can perform a double buffer update of the DAC registers, which in turn simultaneously changes the analog output voltages to a new value. If the \(\overline{\mathrm{LDA}}\) and \(\overline{\mathrm{LDB}}\) pins are wired low, they become transparent. In this mode the input register data will directly control the output voltages. Refer to the Control Logic Truth Table for a complete description.
Unipolar Output Operation
This is the basic mode of operation for the AD8582. The AD8582 has been designed to drive loads as low as \(820 \Omega\) in parallel with 500 pF . The code table for this operation is shown in Table II.

Table II. Unipolar Code Table
\begin{tabular}{l|l|l}
\hline \begin{tabular}{l} 
Hexadecimal \\
Number in DAC \\
Register
\end{tabular} & \begin{tabular}{l} 
Decimal Number \\
in DAC Register
\end{tabular} & \begin{tabular}{l} 
Analog Output \\
Voltage (V)
\end{tabular} \\
\hline FFF & 4095 & +4.095 \\
801 & 2049 & +2.049 \\
800 & 2048 & +2.048 \\
7 FF & 2047 & +2.047 \\
000 & 0 & 0 \\
\hline
\end{tabular}

\section*{AD8582-Typical Performance Characteristics}


Figure 5. Output Swing vs. Load


Figure 8. Broadband Noise


Figure 11. Midscale Transition Performance


Figure 6. Pull-Down Voltage vs. Output Sink Current Capability


Figure 9. Supply Current vs. Logic Input Voltage


Figure 12. Large Signal Settiing Time


Figure 7. Iout vs. Vout


Figure 10. Power Supply Rejection vs. Frequency


Figure 13. Output Voitage Rise Time Detail


Figure 14. Output Voltage Fall Time Detail


Figure 17. Zero-Scale Voltage vs. Temperature


Figure 20. Supply Current vs. Temperature


Figure 15. Total Unadjusted Error Histogram


Figure 18. Output Voltage Noise Density vs. Frequency


Figure 16. Full-Scale Voltage vs.
Temperature


Figure 19. Long-Term Drift Accelerated by Burn-In


Figure 21. Reference Startup vs. Time


Figure 22. Digital Feedthrough vs. Time


Figure 23. Reference Error vs. Temperature


Figure 24. Reference Load Regulation vs. Temperature


Figure 25. Reference Line Regulation vs. Temperature

\section*{FEATURES}

\author{
16 Independently Addressable Voltage Outputs \\ Full-Scale Set by External Reference \\ \(2 \mu\) s Settling Time \\ Double Buffered 8-Bit Parallel Input \\ High Speed Data Load Rate \\ Data Readback \\ Operates from Single +5 V \\ Optional \(\pm 6\) V Supply Extends Output Range
}

APPLICATIONS
Phased Array Ultrasound \& Sonar
Power Level Setting
Receiver Gain Setting
Automatic Test Equipment
LCD Clock Level Setting

\section*{GENERAL DESCRIPTION}

The AD8600 contains 16 independent voltage output digital-toanalog converters that share a common external reference input voltage. Each DAC has its own DAC register and input register to allow double buffering. An 8-bit parallel data input, four address pins, a \(\overline{\mathrm{CS}}\) select, a \(\overline{\mathrm{LD}}, \overline{\mathrm{EN}}, \mathrm{R} / \overline{\mathrm{W}}\), and \(\overline{\mathrm{RS}}\) provide the digital interface.
The AD8600 is constructed in a monolithic CBCMOS process which optimizes use of CMOS for logic and bipolar for speed and precision. The digital-to-analog converter design uses voltage mode operation ideally suited to single supply operation. The internal DAC voltage range is fixed at DACGND to \(\mathrm{V}_{\mathrm{REF}}\). The voltage buffers provide an output voltage range that approaches ground and extends to 1.0 V below \(\mathrm{V}_{\mathrm{CC}}\). Changes in reference voltage values and digital inputs will settle within \(\pm 1 \mathrm{LSB}\) in \(2 \mu \mathrm{~s}\).

Data is preloaded into the input registers one at a time after the internal address decoder selects the input register. In the write mode ( \(\mathrm{R} / \overline{\mathrm{W}}\) low) data is latched into the input register during the positive edge of the \(\overline{\mathrm{EN}}\) pulse. Pulses as short as 40 ns can be used to load the data. After changes have been submitted to the input registers, the DAC registers are simultaneously updated by a common load \(\overline{\mathrm{EN}} \times \overline{\mathrm{LD}}\) strobe. The new analog output voltages simultaneously appear on all 16 outputs.
At system power up or during fault recovery the reset \((\overline{\mathrm{RS}})\) pin forces all DAC registers into the zero state which places zero volts at all DAC outputs.
The AD8600 is offered in the PLCC-44 package. The device is designed and tested for operation over the extended industrial temperature range of \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\).
*Patent pending.

\section*{FUNCTIONAL BLOCK DIAGRAM}



Figure 1. Equivalent DAC Channel
PIN CONFIGURATION
 complete data sheet, call our fax retrieval system at 1-800-446-6212.

\section*{AD8600-SPECIFICATIONS}

SINGLE SUPPLY (@ \(V_{D D 1}=V_{D D 2}=V_{C C}=+5 V \pm 5 \%, V_{E E}=0 \quad V, V_{R E F}=+2.500 V,-40^{\circ} \mathrm{C} \leq T_{A} \leq+85^{\circ} \mathrm{C}\), unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline Parameter & Symbol & Condition & Min & Typ & Max & Units \\
\hline \begin{tabular}{l}
STATIC PERFORMANCE \({ }^{1}\) \\
Resolution \\
Relative Accuracy \({ }^{2}\) Differential Nonlinearity \({ }^{2}\) Full-Scale Voltage Full-Scale Tempco Zero Scale Error Reference Input Resistance
\end{tabular} & \begin{tabular}{l}
N \\
INL \\
DNL \\
\(\mathrm{V}_{\mathrm{FS}}\) \\
\(\mathrm{TCV}_{\mathrm{FS}}\) \\
\(\mathrm{V}_{\text {ZSE }}\) \\
\(\mathrm{V}_{\text {ZSE }}\) \\
\(\mathrm{R}_{\text {REF }}\)
\end{tabular} & Guaranteed Monotonic
\[
\begin{aligned}
& \text { Data }=\mathrm{FF}_{\mathrm{H}} \\
& \text { Data }=\mathrm{FF}_{\mathrm{H}} \\
& \text { Data }=00_{\mathrm{H}}, \overline{\mathrm{RS}}=" 0, " \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\
& \text { Data }=00_{\mathrm{H}}, \overline{\mathrm{RS}}=" 0 " \\
& \text { Data }=\mathrm{AB}_{\mathrm{H}}
\end{aligned}
\] & \begin{tabular}{l}
8 \\
\(-1\) \\
-1 \\
2.480 \\
1.2
\end{tabular} & \[
\begin{aligned}
& \pm 1 / 2 \\
& \pm 1 / 4 \\
& 2.490 \\
& \pm 20 \\
& \\
& 2
\end{aligned}
\] & \[
\begin{aligned}
& +1 \\
& +1 \\
& 2.500 \\
& +3.5 \\
& +5
\end{aligned}
\] & \begin{tabular}{l}
Bits \\
LSB \\
LSB \\
V \\
ppm \(/{ }^{\circ} \mathrm{C}\) \\
LSB \\
LSB \\
k \(\Omega\)
\end{tabular} \\
\hline \begin{tabular}{l}
ANALOG OUTPUT \\
Output Voltage Range \({ }^{2}\) \\
Output Current Capacitive Load
\end{tabular} & \[
\begin{aligned}
& \mathrm{OVR}_{\mathrm{SS}} \\
& \mathrm{I}_{\mathrm{OUT}} \\
& \mathrm{C}_{\mathrm{L}} \\
& \hline
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{REF}}=+2.5 \mathrm{~V} \\
& \text { Data }=80_{\mathrm{H}} \\
& \text { No Oscillation }
\end{aligned}
\] & 0.000 & \[
\begin{aligned}
& \pm 2 \\
& 50
\end{aligned}
\] & 2.500 & \begin{tabular}{l}
V \\
mA \\
pF
\end{tabular} \\
\hline \begin{tabular}{l}
LOGIC INPUTS \\
Logic Input Low Voltage Logic Input High Voltage Logic Input Current Logic Input Capacitance \({ }^{3}\)
\end{tabular} & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{IL}} \\
& \mathrm{~V}_{\mathrm{IH}} \\
& \mathrm{I}_{\mathrm{IL}} \\
& \mathrm{C}_{\mathrm{IL}}
\end{aligned}
\] & & 2.4 & & \[
\begin{aligned}
& 0.8 \\
& 10 \\
& 10
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{~V} \\
& \mu \mathrm{~A} \\
& \mathrm{pF}
\end{aligned}
\] \\
\hline LOGIC OUTPUTS Logic Out High Voltage Logic Out Low Voltage & \begin{tabular}{l}
\(\mathrm{V}_{\mathrm{OH}}\) \\
\(\mathrm{V}_{\mathrm{OL}}\)
\end{tabular} & \[
\begin{aligned}
& \mathrm{I}_{\mathrm{OH}}=-0.4 \mathrm{~mA} \\
& \mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}
\end{aligned}
\] & 3.5 & & 0.4 & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{~V}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
AC CHARACTERISTICS \({ }^{3}\) \\
Slew Rate \\
Voltage Output Settling Time \({ }^{2}\) \\
Voltage Output Settling Time \({ }^{2}\)
\end{tabular} & \[
\begin{aligned}
& \mathrm{SR} \\
& \mathrm{t}_{\mathrm{s}_{1}} \\
& \mathrm{t}_{\mathrm{S} 2}
\end{aligned}
\] & For \(\Delta \mathrm{V}_{\text {REF }}\) or FS Code Change \(\pm 1\) LSB of Final Value, Full-Scale Data Change \(\pm 1 \mathrm{LSB}\) of Final Value, \(\Delta \mathrm{V}_{\mathrm{REF}}=1 \mathrm{~V}\), Data \(=\mathrm{FF}_{\mathrm{H}}\) & 4 & \[
\begin{aligned}
& 2 \\
& 2
\end{aligned}
\] & & \[
\begin{aligned}
& \mathrm{V} / \mu \mathrm{s} \\
& \mu \mathrm{~s} \\
& \mu \mathrm{~s} \\
& \hline
\end{aligned}
\] \\
\hline \begin{tabular}{l}
POWER SUPPLIES \\
Positive Supply Current \\
Logic Supply Currents \\
Power Dissipation \\
Power Supply Sensitivity Logic Power Supply Range Positive Power Supply Range \({ }^{3}\)
\end{tabular} & \begin{tabular}{l}
\(\mathrm{I}_{\mathrm{CC}}\) \\
I \({ }_{\text {DD1\&2 }}\) \\
\(P_{\text {DISS }}\) \\
PSS \\
\(\mathrm{V}_{\mathrm{DDR}}\) \\
\(\mathrm{V}_{\mathrm{CCR}}\)
\end{tabular} & \begin{tabular}{l}
\(\mathrm{V}_{\mathrm{IH}}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0 \mathrm{~V}\), No Load \\
\(\mathrm{V}_{\mathrm{IH}}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0 \mathrm{~V}\), No Load \\
\(\mathrm{V}_{\mathrm{IH}}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0 \mathrm{~V}\), No Load
\[
\Delta \mathrm{V}_{\mathrm{CC}}= \pm 5 \%
\]
\end{tabular} & \[
\begin{aligned}
& 4.75 \\
& \mathrm{~V}_{\mathrm{DD}}
\end{aligned}
\] & \[
\begin{aligned}
& 24 \\
& 120
\end{aligned}
\] & \[
\begin{aligned}
& 35 \\
& 0.1 \\
& 175 \\
& 0.007 \\
& 5.25 \\
& 7.0
\end{aligned}
\] & \begin{tabular}{l}
mA \\
mA \\
mW \\
\%/\% \\
V \\
V
\end{tabular} \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) When \(\mathrm{V}_{\text {REF }}=2.500 \mathrm{~V}, 1 \mathrm{LSB}=9.76 \mathrm{mV}\).
\({ }^{2}\) Single supply operation does not include the final 2 LSBs near analog ground. If this performance is critical, use a negative supply ( \(\mathrm{V}_{\mathrm{EE}}\) ) pin of at least -0.7 V to -5.25 V . Note that for the INL measurement zero-scale voltage is extrapolated using codes \(7_{10}\) to \(80_{10}\).
\({ }^{3}\) Guaranteed by design not subject to production test.
Specifications subject to change without notice.

\section*{ABSOLUTE MAXIMUM RATINGS}
( \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) unless otherwise noted)
\(\mathrm{V}_{\mathrm{DD} 1}\) (Digital Supply) to GND . . . . . . . . . . . . . . \(0.3 \mathrm{~V},+7 \mathrm{~V}\)
\(\mathrm{V}_{\mathrm{DD} 2}\) (DAC Buffer/Driver Supply) . . . . . . . . . . . . \(-0.3 \mathrm{~V},+7 \mathrm{~V}\)
\(\mathrm{V}_{\mathrm{CC}}\) (Analog Supply) to GND . . . . . . . . . . . . . . . \(-0.3 \mathrm{~V},+7 \mathrm{~V}\)
\(\mathrm{V}_{\mathrm{EE}}\) (Analog Supply) to GND . . . . . . . . . . . . . . . \(+0.3 \mathrm{~V},-7 \mathrm{~V}\)
\(\mathrm{V}_{\mathrm{REF}}\) to \(\mathrm{GND} . . . . .\).

Vout to GND . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . V \(_{\text {CC }}\)
Short Circuit Duration
Vout to GND or Power Supplies \({ }^{1}\) \(\qquad\) Continuous

Digital Input/Output Voltage to GND \(\ldots-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}\) Thermal Resistance-Theta Junction-to-Ambient ( \(\theta_{\mathrm{JA}}\) )
```

PLCC-44 . . . . $47^{\circ} \mathrm{C} / \mathrm{W}$

```

Package Power Dissipation . . . . . . . . . . . . . . . . \(\left(T_{J}-T_{A}\right) / \theta_{J A}\)
Maximum Junction Temperature \(\mathrm{T}_{\mathrm{J}} \max \ldots . . . . . .\).
Operating Temperature Range . . . . . . . . . . . \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
Storage Temperature Range . . . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Lead Temperature (Soldering, 10 sec ) . . . . . . . . . . . . . \(+300^{\circ} \mathrm{C}\)
NOTE
\({ }^{1}\) No more than four outputs may be shorted to power or GND simultaneously.

DUAL SUPPLY (@ \(V_{001}=V_{D 02}=V_{C C}=+5 V \pm 5 \%, V_{E E}=-5 V \pm 5 \%, V_{\text {REF }}=+3.500 V,-40^{\circ} \mathrm{C} \leq T_{A} \leq+85^{\circ} \mathrm{C}\), unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline Parameter & Symbol & Condition & Min & Typ & Max & Units \\
\hline \begin{tabular}{l}
STATIC PERFORMANCE \({ }^{1}\) \\
Resolution \\
Total Unadjusted Error \\
Relative Accuracy \\
Differential Nonlinearity \\
Full-Scale Voltage \\
Full-Scale Voltage Error \\
Full-Scale Tempco \\
Zero Scale Error \\
Zero Scale Error \\
Zero Scale Error \\
Zero Scale Tempco \\
Reference Input Resistance \\
Reference Input Capacitance \({ }^{2}\)
\end{tabular} & \[
\begin{aligned}
& \mathrm{N} \\
& \mathrm{TUE} \\
& \mathrm{INL} \\
& \mathrm{DNL} \\
& \mathrm{~V}_{\mathrm{FS}} \\
& \mathrm{~V}_{\mathrm{FSE}} \\
& \mathrm{TCV} \\
& \mathrm{~V}_{\mathrm{FSE}} \\
& \mathrm{~V}_{\mathrm{ZSE}} \\
& \mathrm{~V}_{\mathrm{ZSE}} \\
& \mathrm{TCV}_{\mathrm{ZS}} \\
& \mathrm{R}_{\mathrm{REF}} \\
& \mathrm{C}_{\text {REF }}
\end{aligned}
\] & All Other DACs Loaded with Data \(=55_{\mathrm{H}}\)
\[
\begin{aligned}
& \text { Guaranteed Monotonic } \\
& \text { Data }=\mathrm{FF}_{\mathrm{H}}, \mathrm{~V}_{\mathrm{REF}}=+3.5 \mathrm{~V} \\
& \text { Data }=\mathrm{FF}_{\mathrm{H}}, \mathrm{~V}_{\mathrm{REF}}=+3.5 \mathrm{~V} \\
& \text { Data }=\mathrm{FF}_{\mathrm{H}}, \mathrm{~V}_{\mathrm{REF}}=+3.5 \mathrm{~V} \\
& \text { Data }=00_{\mathrm{H}}, \mathrm{RS}=" 0, " \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\
& \text { Data }=00_{\mathrm{H}}, \text { All Other DACs Data }=00_{\mathrm{H}} \\
& \text { Data }=00_{\mathrm{H}}, \text { All Other DACs Data }=55_{\mathrm{H}} \\
& \text { Data }=00_{\mathrm{H}}, \mathrm{~V}_{\mathrm{CC}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-5 \mathrm{~V} \\
& \text { Data }=\mathrm{AB}_{\mathrm{H}} \\
& \text { Data }=\mathrm{AB}_{\mathrm{H}}
\end{aligned}
\] & \[
\begin{array}{|l}
8 \\
-1 \\
-1 \\
-1 \\
3.473 \\
-1 \\
\\
-2 \\
-1 \\
\\
1.2
\end{array}
\] & \[
\begin{aligned}
& \pm 3 / 4 \\
& \pm 1 / 2 \\
& \pm 1 / 4 \\
& 3.486 \\
& \\
& \pm 20 \\
& \pm 1 \\
& \\
& \pm 1 / 2 \\
& \pm 10 \\
& 2
\end{aligned}
\] & \begin{tabular}{l}
\(+1\) \\
\(+1\) \\
\(+1\) \\
3.500 \\
\(+1\) \\
\(+2\) \\
\(+1\) \\
240
\end{tabular} & \[
\begin{aligned}
& \text { Bits } \\
& \mathrm{LSB} \\
& \mathrm{LSB} \\
& \mathrm{LSB} \\
& \mathrm{~V} \\
& \mathrm{LSB} \\
& \mathrm{ppm} /{ }^{\circ} \mathrm{C} \\
& \mathrm{mV} \\
& \mathrm{LSB} \\
& \mathrm{LSB} \\
& \mu \mathrm{~V} /{ }^{\circ} \mathrm{C} \\
& \mathrm{k} \Omega \\
& \mathrm{pF} \\
& \hline
\end{aligned}
\] \\
\hline ANALOG OUTPUT Output Voltage Range Output Voltage Range \({ }^{2}\) Output Current Capacitive Load \({ }^{2}\) & \begin{tabular}{l}
\(\mathrm{OVR}_{1}\) \\
\(\mathrm{OVR}_{2}\) \\
\(\mathrm{I}_{\text {OUT }}\) \\
\(\mathrm{C}_{\mathrm{L}}\)
\end{tabular} & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{REF}}=+3.5 \mathrm{~V} \\
& \mathrm{~V}_{\mathrm{CC}}=\mathrm{V}_{\mathrm{DD} 2}=+7 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-0.7 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}}=5 \mathrm{~V} \\
& \text { Data }=80_{\mathrm{H}} \\
& \text { No Oscillation }
\end{aligned}
\] & \[
\begin{aligned}
& 0.000 \\
& 0.000
\end{aligned}
\] & \[
\begin{aligned}
& \pm 2 \\
& 50
\end{aligned}
\] & \[
\begin{aligned}
& 3.500 \\
& 5.000
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{~V} \\
& \mathrm{~mA} \\
& \mathrm{pF}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
LOGIC INPUTS \\
Logic Input Low Voltage Logic Input High Voltage Logic Input Current Logic Input Capacitance \({ }^{2}\)
\end{tabular} & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{IL}} \\
& \mathrm{~V}_{\mathrm{IH}} \\
& \mathrm{I}_{\mathrm{IL}} \\
& \mathrm{C}_{\mathrm{IL}}
\end{aligned}
\] & & 2.4 & & \[
\begin{aligned}
& 0.8 \\
& 10 \\
& 10
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{~V} \\
& \mu \mathrm{~A} \\
& \mathrm{pF}
\end{aligned}
\] \\
\hline LOGIC OUTPUTS Logic Out High Voltage Logic Out Low Voltage & \begin{tabular}{l}
\(\mathrm{V}_{\mathrm{OH}}\) \\
\(\mathrm{V}_{\mathrm{OL}}\)
\end{tabular} & \[
\begin{aligned}
& \mathrm{I}_{\mathrm{OH}}=-0.4 \mathrm{~mA} \\
& \mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}
\end{aligned}
\] & 3.5 & & 0.4 & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{~V}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
AC CHARACTERISTICS \({ }^{2}\) \\
Reference In Bandwidth \\
Slew Rate \\
Voltage Noise Density \\
Digital Feedthrough \\
Voltage Output Settling Time \({ }^{3}\) \\
Voltage Output Settling Time \({ }^{3}\)
\end{tabular} & \[
\begin{aligned}
& \mathrm{BW} \\
& \mathrm{SR} \\
& \mathrm{e}_{\mathrm{N}} \\
& \mathrm{FT} \\
& \mathrm{t}_{\mathrm{S} 1} \\
& \mathrm{t}_{\mathrm{S} 2} \\
& \hline
\end{aligned}
\] & \begin{tabular}{l}
-3 dB Frequency, \(\mathrm{V}_{\mathrm{REF}}=2.5 \mathrm{~V}_{\mathrm{DC}}+0.1 \mathrm{~V}_{\mathrm{AC}}\) \\
For \(\Delta \mathrm{V}_{\mathrm{REF}}\) or FS Code Change
\[
\mathrm{f}=1 \mathrm{kHz}, \mathrm{~V}_{\mathrm{REF}}=0 \mathrm{~V}
\] \\
Digital Inputs to DAC Outputs \\
\(\pm 1\) LSB of Final Value, FS Data Change \\
\(\pm 1 \mathrm{LSB}\) of Final Value, \(\Delta \mathrm{V}_{\text {REF }}=1 \mathrm{~V}\), Data \(=\mathrm{FF}_{\mathrm{H}}\)
\end{tabular} & & \[
\begin{aligned}
& 7 \\
& 46 \\
& 10 \\
& 1 \\
& 1
\end{aligned}
\] & \[
\begin{aligned}
& 2 \\
& 2
\end{aligned}
\] & \begin{tabular}{l}
kHz \\
V/ \(/ \mathrm{s}\) \(\mathrm{nV} / \sqrt{\mathrm{Hz}}\) nVs \\
\(\mu \mathrm{s}\) \\
\(\mu \mathrm{s}\)
\end{tabular} \\
\hline \begin{tabular}{l}
POWER SUPPLIES \\
Positive Supply Current Negative Supply Current Logic Supply Currents Power Dissipation \({ }^{4}\) Power Supply Sensitivity Logic Power Supply Range Pos Power Supply Range \({ }^{2}\) Neg Power Supply Range \({ }^{2}\)
\end{tabular} & \begin{tabular}{l}
\(\mathrm{I}_{\mathrm{CC}}\) \\
\(\mathrm{I}_{\mathrm{EE}}\) \\
\(\mathrm{I}_{\text {DD1\&2 }}\) \\
\(\mathrm{P}_{\text {DISS }}\) \\
PSS \\
\(\mathrm{V}_{\mathrm{DDR}}\) \\
\(\mathrm{V}_{\mathrm{CCR}}\) \\
\(V_{\text {EER }}\)
\end{tabular} & \begin{tabular}{l}
\(\mathrm{V}_{\mathrm{IH}}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-5 \mathrm{~V}\), No Load \\
\(\mathrm{V}_{\mathrm{IH}}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-5 \mathrm{~V}\), No Load \\
\(\mathrm{V}_{\mathrm{IH}}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-5 \mathrm{~V}\), No Load \\
\(\mathrm{V}_{\mathrm{IH}}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-5 \mathrm{~V}\), No Load \\
\(\Delta \mathrm{V}_{\mathrm{CC}} \& \Delta \mathrm{~V}_{\mathrm{EE}}= \pm 5 \%\)
\end{tabular} & \begin{tabular}{l}
4.75 \\
\(V_{D D}\) \\
\(-5.25\)
\end{tabular} & \[
\begin{aligned}
& 22 \\
& 22 \\
& \\
& 225
\end{aligned}
\] & \[
\begin{aligned}
& 35 \\
& 35 \\
& 0.1 \\
& 350 \\
& 0.007 \\
& 5.25 \\
& 7.0 \\
& 0.0
\end{aligned}
\] & \begin{tabular}{l}
mA \\
mA \\
mA \\
mW \\
\%/\% \\
V \\
V \\
V
\end{tabular} \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) When \(\mathrm{V}_{\text {REF }}=+3.500 \mathrm{~V}, 1 \mathrm{LSB}=13.67 \mathrm{mV}\).
\({ }^{2}\) Guaranteed by design not subject to production test.
\({ }^{3}\) Settling time test is performed using \(\mathrm{R}_{\mathrm{L}}=50 \mathrm{k} \Omega\) and \(\mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}\).
\({ }^{4}\) Power Dissipation is calculated using \(5 \mathrm{~V} \times\left(\mathrm{I}_{\mathrm{DD}}+\left|\mathrm{I}_{\mathrm{SS}}\right|+\mathrm{I}_{\mathrm{DD} 1}+\mathrm{I}_{\mathrm{DD} 2}\right)\).
Specifications subject to change without notice.

\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD8600 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


EIECTRICAL CHARACTERISTICS \({ }^{(@} \mathrm{V}_{\mathrm{DD1}}=\mathrm{V}_{\mathrm{DD2}}=\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{EE}}=-5 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}}=+3.500 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}\),
ELECTRICAL CHARACTERISTICS unless otherwise noted)
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline Parameter & Symbol & Condition & Min & Typ & Max & Units \\
\hline INTERFACE TIMING \({ }^{1,2}\) & & & & & & \\
\hline Clock ( \(\overline{\mathrm{EN}}\) ) Frequency & \(\mathrm{f}_{\text {CLK }}\) & Data Loading & & & 12.5 & MHz \\
\hline Clock (EN) High Pulse Width & \(\mathrm{t}_{\mathrm{CH}}\) & & 40 & & & ns \\
\hline Clock (EN) LowPulse Width & \(\mathrm{t}_{\mathrm{CL}}\) & & 40 & & & ns \\
\hline Data Setup Time & \(\mathrm{t}_{\mathrm{DS}}\) & & 40 & & & ns \\
\hline Data Hold Time & \(\mathrm{t}_{\mathrm{DH}}\) & & 10 & & & ns \\
\hline Address Setup Time & \(\mathrm{t}_{\text {AS }}\) & & 0 & & & ns \\
\hline Address Hold Time & \(\mathrm{t}_{\text {AH }}\) & & 0 & & & ns \\
\hline Valid Address to Data Valid & \(\mathrm{t}_{\mathrm{AD}}\) & & & & 160 & ns \\
\hline Load Enable Setup Time & \(\mathrm{t}_{\mathrm{L}}\) & & 0 & & & ns \\
\hline Load Enable Hold Time & \(\mathrm{t}_{\mathrm{LH}}\) & & 0 & & & ns \\
\hline Read/Write to Clock ( \(\overline{\mathrm{EN}}\) ) & \(\mathrm{t}_{\text {RWC }}\) & & 30 & & & ns \\
\hline Read/Write to DataBus Hi-Z & \(\mathrm{t}_{\text {RWZ }}\) & & & & 120 & ns \\
\hline Read/Write to DataBus Active & \(\mathrm{t}_{\text {RWD }}\) & & & & 120 & ns \\
\hline Clock ( \(\overline{\mathrm{EN}}\) ) to Read/Write & \(\mathrm{t}_{\text {TWH }}\) & & 0 & & & ns \\
\hline Clock (EN) to Chip Select & \(\mathrm{t}_{\mathrm{TCH}}\) & & 0 & & & ns \\
\hline Chip Select to Clock ( \(\overline{\mathrm{EN}}\) ) & \(\mathrm{t}_{\text {CSC }}\) & & 30 & & & ns \\
\hline Chip Select to Data Valid & \(\mathrm{t}_{\text {CSD }}\) & & & & 120 & ns \\
\hline Chip Select to DataBus Hi-Z & \(\mathrm{t}_{\text {CSZ }}\) & & & & 150 & ns \\
\hline Reset Pulse Width - & \(\mathrm{t}_{\text {RS }}\) & & 25 & & & ns \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Guaranteed by design not subject to production test.
\({ }^{2}\) All logic input signals have maximum rise and fall times of 2 ns .
Specifications subject to change without notice.


Figure 2. Write Timing



Figure 3. Readback Timing

ORDERING GUIDE
\begin{tabular}{l|l|l|l}
\hline Model & Temperature & \begin{tabular}{l} 
Package \\
Description
\end{tabular} & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD8600AP & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \begin{tabular}{l}
44 -Lead PLCC \\
Die \(^{2}\)
\end{tabular} & P-44A \\
AD8600Chips & \(+25^{\circ} \mathrm{C}\) & \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) For outline information see Package Information section.
\({ }^{2}\) For die specifications contact your local Analog Devices sales office. The AD8600 contains 5782 transistors.

Figure 4. Write to DAC Register \& Voltage Output Settling Timing (CS = High, Prevents Input Register Changes)

\section*{FEATURES}

Low Cost
Replaces 8 Potentiometers
50 kHz 4-Quadrant Multiplying Bandwidth
Low Zero Output Error
Eight Individual Channels
3-Wire Serial Input
500 kHz Update Data Loading Rate
\(\pm 3\) V Output Swing
Midscale Preset, Zero Volts Out

\section*{APPLICATIONS}

\section*{Automatic Adjustment}

Trimmer Replacement
Vertical Deflection Amplitude Adjustment
Waveform Generation and Modulation

\section*{GENERAL DESCRIPTION}

The AD8842 provides eight general purpose digitally controlled voltage adjustment devices. The TrimDAC \({ }^{\circledR}\) capability allows replacement of the mechanical trimmer function in new designs. The AD8842 is ideal for ac or dc gain control of up to 50 kHz bandwidth signals. The four-quadrant multiplying capability is useful for signal inversion and modulation often found in video vertical deflection circuitry.
Internally the AD8842 contains eight voltage output digital-toanalog converters, each with separate voltage inputs. A new current conveyor amplifier design performs the four-quadrant multiplying function with a single amplifier at the output of the current steering digital-to-analog converter. This approach offers an improved constant input resistance performance versus previous voltage switched DACs used in TrimDAC circuits, eliminating the need for additional input buffer amplifiers.
Each DAC has its own DAC register that holds its output state. These DAC registers are updated from an internal serial-toparallel shift register that is loaded from a standard 3-wire serial input digital interface. Twelve data bits make up the data word clocked into the serial input register. This data word is decoded where the first 4 bits determine the address of the DAC register to be loaded with the last 8 bits of data. A serial data output pin at the opposite end of the serial register allows simple daisy chaining in multiple DAC applications without additional external decoding logic.

\footnotetext{
TrimDAC is a registered trademark of Analog Devices, Inc.
The current conveyor amplifier is a patented circuit belonging to Analog Devices, Inc.
}

FUNCTIONAL BLOCK DIAGRAM


The AD8842 consumes only 95 mW from \(\pm 5 \mathrm{~V}\) power supplies. For single 5 V supply applications consult the DAC-8841. The AD 8842 is pin compatible with the 1 MHz multiplying bandwidth DAC8840. The AD8842 is available in 24 -pin plastic DIP and surface mount SOL-24 packages.


Figure 1. Functional Circuit of One 4-Quadrant Multiplying Channel


Figure 2. Actual Current Conveyor Implementation of Multiplying DAC Channel

This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

\section*{AD8842-SPECIFICATIONS}

\begin{tabular}{|c|c|c|c|c|c|c|}
\hline Parameter & Symbol & Conditions & Min & Typ & Max & Units \\
\hline \begin{tabular}{l}
STATIC ACCURACY—All Specific \\
Resolution \\
Integral Nonlinearity Error \\
Differential Nonlinearity \\
Full-Scale Gain Error \\
Output Offset \\
Output Offset Drift
\end{tabular} & \begin{tabular}{l}
ns Apply \\
N \\
INL \\
DNL \\
\(\mathrm{G}_{\mathrm{FSE}}\) \\
\(V_{\text {BZE }}\) \\
\(\mathrm{TCV}_{\mathrm{B} Z}\)
\end{tabular} & \begin{tabular}{l}
DACs A, B, C, D, E, F, G, H \\
All Devices Monotonic
\[
\begin{aligned}
& \overline{\mathrm{PR}}=0, \text { Sets } \mathrm{D}=80_{\mathrm{H}} \\
& \overline{\mathrm{PR}}=0, \text { Sets } \mathrm{D}=80_{\mathrm{H}}
\end{aligned}
\]
\end{tabular} & 8 & \[
\begin{aligned}
& \pm 0.2 \\
& \pm 0.4 \\
& 2 \\
& 5 \\
& 5
\end{aligned}
\] & \[
\begin{aligned}
& \pm 1 \\
& \pm 1 \\
& 25
\end{aligned}
\] & Bits LSB LSB LSB mV \(\mu \mathrm{V} /{ }^{\circ} \mathrm{C}\) \\
\hline \begin{tabular}{l}
VOLTAGE INPUTS-Applies to All \\
Input Voltage Range \({ }^{1}\) \\
Input Resistance \\
Input Capacitance
\end{tabular} & \[
\begin{aligned}
& \text { nputs } \mathrm{V}_{\mathrm{IN}} \mathrm{X} \\
& \mathrm{IVR} \\
& \mathrm{R}_{\mathrm{IN}} \\
& \mathrm{C}_{\mathrm{IN}} \\
& \hline
\end{aligned}
\] & & \[
\begin{aligned}
& \pm 3 \\
& 12
\end{aligned}
\] & \[
\begin{aligned}
& \pm 4 \\
& 19 \\
& 9
\end{aligned}
\] & & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{k} \Omega \\
& \mathrm{pF}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
DAC OUTPUTS-Applies to All Ou \\
Voltage Range \({ }^{1}\) \\
Output Current \\
Capacitive Load
\end{tabular} & \[
\begin{aligned}
& \text { uts } V_{\text {out }} \\
& \text { OVR } \\
& I_{\text {OUT }} \\
& \mathrm{C}_{\mathrm{L}}
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \\
& \Delta \mathrm{~V}_{\text {OuT }}<1.5 \mathrm{LSB} \\
& \text { No Oscillation }
\end{aligned}
\] & \[
\begin{aligned}
& \pm 3 \\
& \pm 3
\end{aligned}
\] & \[
\begin{aligned}
& \pm 4 \\
& 500
\end{aligned}
\] & & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{~mA} \\
& \mathrm{pF}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
DYNAMIC PERFORMANCE-App \\
Full Power Gain Bandwidth \({ }^{1}\) \\
Slew Rate \\
Positive \\
Negative \\
Total Harmonic Distortion \\
Spot Noise Voltage \\
Output Settling Time \\
Channel-to-Channel Crosstalk \\
Digital Feedthrough
\end{tabular} & \begin{tabular}{l}
to All D \\
GBW \\
SR+ \\
SR- \\
THD \\
\(e_{N}\) \\
\(t_{s}\) \\
\(\mathrm{C}_{\mathrm{T}}\) \\
Q
\end{tabular} & \begin{tabular}{l}
\[
\mathrm{V}_{\mathrm{IN}} \mathrm{X}= \pm 3 \mathrm{~V}_{\mathrm{P}}, \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}
\] \\
Measured \(10 \%\) to \(90 \%\) \\
\(\Delta \mathrm{V}_{\text {OUTX }}=+5.5 \mathrm{~V}\) \\
\(\Delta \mathrm{V}_{\text {OUT }} \mathrm{x}=-5.5 \mathrm{~V}\) \\
\(\mathrm{V}_{\mathrm{IN}} \mathrm{X}=4 \mathrm{~V} \mathrm{p}-\mathrm{p}, \mathrm{D}=\mathrm{FF}_{\mathrm{H}}, \mathrm{f}=1 \mathrm{kHz}\), \\
\(\mathrm{f}_{\mathrm{LPF}}=80 \mathrm{kHz}, \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega\) \\
\(\mathrm{f}=1 \mathrm{kHz}, \mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}\) \\
\(\pm 1 \mathrm{LSB}\) Error Band, \(\mathrm{D}=00_{\mathrm{H}}\) to \(\mathrm{FF}_{\mathrm{H}}\)
\[
\mathrm{D}=\mathrm{FF}_{\mathrm{H}} \text { to } 00_{\mathrm{H}}
\] \\
Measured Between Adjacent \\
Channels, \(\mathrm{f}=100 \mathrm{kHz}\) \\
\(\mathrm{V}_{\mathrm{IN}} \mathrm{X}=0 \mathrm{~V}, \mathrm{D}=0\) to \(255_{10}\)
\end{tabular} & \[
\begin{aligned}
& 10 \\
& 0.5 \\
& 1.0
\end{aligned}
\] & 50
1.0
1.8
0.01
78
2.9
5.4
72
5 & & \begin{tabular}{l}
kHz \\
V/us \\
\(\mathrm{V} / \mu \mathrm{s}\) \\
\% \\
\(\mathrm{nV} / \sqrt{\mathrm{Hz}}\) \\
\(\mu \mathrm{s}\) \\
\(\mu \mathrm{s}\) \\
dB \\
nV-s
\end{tabular} \\
\hline \begin{tabular}{l}
POWER SUPPLIES \\
Positive Supply Current Negative Supply Current Power Dissipation \({ }^{2}\) Power Supply Rejection Power Supply Range
\end{tabular} & \begin{tabular}{l}
\(\mathrm{I}_{\mathrm{DD}}\) \\
Iss \\
\(P_{\text {DISS }}\) \\
PSRR \\
PSR
\end{tabular} & \[
\begin{aligned}
& \overline{\mathrm{PR}}=0 \mathrm{~V} \\
& \overline{\mathrm{PR}}=0 \mathrm{~V} \\
& \overline{\mathrm{PR}}=0 \mathrm{~V}, \Delta \mathrm{~V}_{\mathrm{DD}}= \pm 5 \% \\
& \mathrm{~V}_{\mathrm{DD}},\left|\mathrm{~V}_{\mathrm{SS}}\right|
\end{aligned}
\] & \[
4.75
\] & \[
\begin{aligned}
& 10 \\
& 9 \\
& 95 \\
& 0.0001 \\
& 5.00
\end{aligned}
\] & \[
\begin{aligned}
& 14 \\
& 13 \\
& 135 \\
& 0.01 \\
& 5.25
\end{aligned}
\] & \begin{tabular}{l}
mA \\
mA \\
mW \\
\%/\% \\
V
\end{tabular} \\
\hline \begin{tabular}{l}
DIGITAL INPUTS \\
Logic High Logic Low Input Current Input Capacitance Input Coding
\end{tabular} & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{IH}} \\
& \mathrm{~V}_{\mathrm{IL}} \\
& \mathrm{I}_{\mathrm{L}} \\
& \mathrm{C}_{\mathrm{IL}}
\end{aligned}
\] & & 2.4 & \begin{tabular}{l}
7 \\
Binary
\end{tabular} & \[
\begin{aligned}
& 0.8 \\
& \pm 10
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{~V} \\
& \mu \mathrm{~A} \\
& \mathrm{pF}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
DIGITAL OUTPUT \\
Logic High \\
Logic Low
\end{tabular} & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{OH}} \\
& \mathrm{~V}_{\mathrm{OL}}
\end{aligned}
\] & \[
\begin{aligned}
\mathrm{I}_{\mathrm{OH}} & =-0.4 \mathrm{~mA} \\
\mathrm{I}_{\mathrm{OL}} & =1.6 \mathrm{~mA}
\end{aligned}
\] & 3.5 & & 0.4 & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{~V}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
TIMING SPECIFICATIONS \({ }^{1}\) \\
Input Clock Pulse Width Data Setup Time Data Hold Time CLK to SDO Propagation Delay DAC Register Load Pulse Width Preset Pulse Width Clock Edge to Load Time Load Edge to Next Clock Edge
\end{tabular} & \begin{tabular}{l}
\(t_{\mathrm{CH}}, \mathrm{t}_{\mathrm{CL}}\) \\
\(\mathrm{t}_{\mathrm{DS}}\) \\
\(\mathrm{t}_{\mathrm{DH}}\) \\
\(t_{\text {PD }}\) \\
\(t_{L D}\) \\
\(t_{P R}\) \\
\(t_{\text {CKLD }}\) \\
\(t_{\text {LDCK }}\)
\end{tabular} & - & \[
\begin{aligned}
& 60 \\
& 40 \\
& 20 \\
& 70 \\
& 50 \\
& 30 \\
& 60 \\
& \hline
\end{aligned}
\] & & 80 & \begin{tabular}{l}
ns \\
ns \\
ns \\
ns \\
ns \\
ns \\
ns \\
ns
\end{tabular} \\
\hline
\end{tabular}

\footnotetext{
NOTES
\({ }^{1}\) Guaranteed by design, not subject to production test.
\({ }^{2}\) Calculated limit \(=5 \mathrm{~V} \times\left(\mathrm{I}_{\mathrm{DD}}+\mathrm{I}_{S S}\right)\).
Specifications subject to change without notice.
}


Figure 3. Timing Diagram

\section*{ABSOLUTE MAXIMUM RATINGS}
( \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) unless otherwise noted)
\(\mathrm{V}_{\mathrm{DD}}\) to GND . . . . . . . . . . . . . . . . . . . . . . . . . . . . . \(-0.3 \mathrm{~V},+7 \mathrm{~V}\)
VSs to GND . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . \(+0.3 \mathrm{~V},-7 \mathrm{~V}\)
V \(_{\text {INX }}\) to GND . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . V \(_{\text {DD }}\), V \(_{\text {SS }}\)
V OUT \(^{x}\) to GND . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . V \(_{\text {DD }}, V_{S S}\)
Short Circuit IOUTX to GND . . . . . . . . . . . . . . . . . . Continuous
Digital Input \& Output Voltage to GND . . . . . . . . . . . V \(\mathrm{V}_{\mathrm{DD}}, 0 \mathrm{~V}\)
Operating Temperature Range . . . . . . . . . . . . \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
Maximum Junction Temperature ( \(\mathrm{T}_{\mathrm{J}} \mathrm{Max}\) ) . . . . . . . . \(+150^{\circ} \mathrm{C}\)
Storage Temperature . . . . . . . . . . . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Lead Temperature (Soldering, 10 sec ) . . . . . . . . . . . . \(+300^{\circ} \mathrm{C}\)
Package Power Dissipation ................ \(\left(\mathrm{T}_{\mathrm{J}} \mathrm{Max}-\mathrm{T}_{\mathrm{A}}\right) / \theta_{\mathrm{JA}}\)
Thermal Resistance \(\theta_{\mathrm{JA}}\),
SOIC (SOL-24) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . \(50^{\circ} \mathrm{C}\) º \(\mathrm{C} / \mathrm{W}\)
P-DIP \((\mathrm{N}-24) ~ . ~ . ~ . ~ . ~ . ~ . ~ . ~\)

\section*{ORDERING GUIDE}
\begin{tabular}{l|l|l|l}
\hline Model & \begin{tabular}{l} 
Temperature \\
Range \(^{\mathbf{1}}\)
\end{tabular} & \begin{tabular}{l} 
Package \\
Description
\end{tabular} & \begin{tabular}{l} 
Package \\
Option \(^{2}\)
\end{tabular} \\
\hline AD8842AN & XIND & 24-Pin 300mil P-DIP & N-24 \\
AD8842AR & XIND & 24-Pin 300mil SOIC & SOL-24 \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) XIND \(=-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\). The AD8842 contains 2452 transistors.
\({ }^{2}\) For outline information see Package Information section.

\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD8842 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

PIN DESCRIPTION
\begin{tabular}{|c|c|c|}
\hline Pin & Mnemonic & Description \\
\hline 1 & \(\mathrm{V}_{\text {OUT }} \mathrm{C}\) & DAC C Output \\
\hline 2 & \(\mathrm{V}_{\text {OUT }} \mathrm{B}\) & DAC B Output \\
\hline 3 & \(V_{\text {OUT }} \mathrm{A}\) & DAC A Output \\
\hline 4 & \(\mathrm{V}_{\text {IN }} \mathrm{B}\) & DAC B Reference Input \\
\hline 5 & \(\mathrm{V}_{\text {IN }} \mathrm{A}\) & DAC A Reference Input \\
\hline 6 & GND & Ground \\
\hline 7 & \(\overline{\mathrm{PR}}\) & Preset Input, active low, all DAC registers \(=80_{\mathrm{H}}\) \\
\hline 8 & \(\mathrm{V}_{\text {IN }} \mathrm{E}\) & DAC E Reference Input \\
\hline 9 & \(\mathrm{V}_{\text {IN }} \mathrm{F}\) & DAC F Reference Input \\
\hline 10 & \(\mathrm{V}_{\text {OUT }} \mathrm{E}\) & DAC E Output \\
\hline 11 & \(V_{\text {OuT }} \mathrm{F}\) & DAC F Output \\
\hline 12 & \(\mathrm{V}_{\text {OUT }} \mathrm{G}\) & DAC G Output \\
\hline 13 & \(\mathrm{V}_{\text {OUT }} \mathrm{H}\) & DAC H Output \\
\hline 14 & \(V_{\text {IN }} G\) & DAC G Reference Input \\
\hline 15 & \(\mathrm{V}_{\text {IN }} \mathrm{H}\) & DAC H Reference Input \\
\hline 16 & LD & Load DAC Register Strobe, activehigh input that transfers the data bits from the serial-input register into the decoded DAC register. SDI and CLK inputs are disabled when LD is high. See Tables I and II \\
\hline 17 & CLK & Serial Clock Input, positive edge triggered \\
\hline 18 & SDO & Serial Data Output, active totem pole output \\
\hline 19 & \(\mathrm{V}_{\text {Ss }}\) & Negative 5 V Power Supply \\
\hline 20 & SDI & Serial Data Input \\
\hline 21 & \(V_{\text {DD }}\) & Positive 5 V Power Supply \\
\hline 22 & \(\mathrm{V}_{\text {IN }} \mathrm{D}\) & DAC D Reference Input \\
\hline 23 & \(\mathrm{V}_{\text {IN }} \mathrm{C}\) & DAC C Reference Input \\
\hline 24 & \(\mathrm{V}_{\text {OUT }} \mathrm{D}\) & DAC D Output \\
\hline
\end{tabular} 250MSPS Video Digital-to-Analog Converter
\(\square\)

\section*{FEATURES}

250MSPS Update Rate
Low Glitch Impulse
Complete Composite Functions
Internal Voltage Reference
Single -5.2V Supply

\section*{APPLICATIONS}

Raster Scan Displays
Color Graphics
Automated Test Equipment
TV Video Reconstruction

\section*{GENERAL DESCRIPTION}

The AD9701 is a high-speed, 8-bit digital-to-analog converter with fully integrated composite video functions. High-speed ECL input registers provide synchronous operation of data and control functions up to 250MSPS.

The AD9701 incorporates on-board control functions including horizontal sync, blanking, reference white level, and a \(10 \%\) bright signal for highlighting. The setup level is also adjustable from 0 IRE units to 20 IRE units, through the control pin. An internal voltage reference allows the AD9701 to operate as a stand-alone video reconstruction DAC.

FUNCTIONAL BLOCK DIAGRAM


The AD9701 is available as an industrial temperature range device, \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\), and as an extended temperature range device, \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\). Both grades of the AD9701 are packaged in a 22 -pin ceramic DIP, with the extended temperature device also available in a 28 -pin LCC package.

PIN CONFIGURATIONS


\section*{ABSOLUTE MAXIMUM RATINGS \({ }^{1}\)}

Supply Voltage ( \(-\mathrm{V}_{\mathrm{s}}\) ) . . . . . . . . . . . . . . . . . . - 7 V
Digital Input Voltages (including STROBE, SYNC, BLANKING, \(10 \%\) BRIGHT, and REFERENCE WHITE) Analog Output Current . . . . . . . . . . . . . . . . . . 37mA
Power Dissipation ( \(+25^{\circ} \mathrm{C}\) Free Air) \({ }^{2}\). . . . . . . . . 780 mW

Operating Temperature Range
AD9701BQ . . . . . . . . . . . . . . . . \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)

AD9701SQ/SE . . . . . . . . . . . . . . \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
Storage Temperature Range . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Junction Temperature . . . . . . . . . . . . . . . . . + \(175^{\circ} \mathrm{C}\)
Lead Soldering Temperature ( 10 sec ) . . . . . . . . . \(+300^{\circ} \mathrm{C}\)

\section*{ELECTRICAL CHARACTERISTICS \({ }_{\text {(Supply Voltages }}=-5.2 V_{;} \mathrm{R}_{\mathrm{L}}=37.5 \Omega\); Setup \(=0 V\), unless otherwise stated)}


NOTES
\({ }^{1}\) Absolute maximum ratings are limiting values, to be applied individually, and beyond which serviceability of the circuit may be impaired. Functional operability under any of these conditions is not necessarily implied.
Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
\({ }^{2}\) Typical thermal impedance . . .
\[
\begin{array}{ll}
\text { 22-Pin Ceramic } & \theta_{\text {ia }}=64^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{ic}}=16^{\circ} \mathrm{C} / \mathrm{W} \\
\text { 28-Pin Ceramic LCC } & \boldsymbol{\theta}_{\mathrm{ja}}=70^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{ic}}=21^{\circ} \mathrm{C} / \mathrm{W}
\end{array}
\]
\({ }^{3}\) SYNC, BLANKING, and REFERENCE WHITE are inactive (Logic " 1 ").
\(\mathrm{I}_{\mathrm{SET}} \approx 1.26 \mathrm{~V} / \mathrm{R}_{\mathrm{SET}}\).
\({ }^{4}\) All bits at logic HIGH.
\({ }^{5}\) All values are relative to full-scale output, after being normalized to nominal value. Typical variation in full-scale output from device to device can reach \(\pm 10 \%\), for a fixed \(R_{\text {SET }}\) resistor.
\({ }^{6}\) The effect of \(10 \%\) BRIGHT algebraically adds to the output waveform.
\({ }^{7}\) The output level with BLANKING active (Logic "0"), is determined by the setup control level.
\({ }^{8}\) In normal operation, the BLANKING input is activated (Logic " 0 ") prior to or in conjunction with the SYNC input. The effect of the SYNC output is relative to the setup level.
\({ }^{9}\) Measured from edge of STROBE to \(50 \%\) transition point of the output signal.
\({ }^{10}\) Measured with full-scale change in output level, from the \(10 \%\) transition level to within \(\pm 0.2 \%\) of the final output value.
\({ }^{11}\) Measured from \(10 \%\) to \(90 \%\) transition point for full-scale step output.
\({ }^{12}\) An IRE unit is \(1 \%\) of the Grey Scale (GS range) with a 0 IRE setup level.
\({ }^{13}\) Supply Voltage should remain stable within \(\pm 5 \%\) for normal operation.
\({ }^{14}\) Measured at \(\pm 5 \%\) of \(-V_{S}\).
Specifications subject to change without notice.

DIGITAL INPUTS VS. ANALOG OUTPUT
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \[
\begin{gathered}
\text { Bit } \\
1
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
2
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
3
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
4
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
5
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
6
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
7
\end{gathered}
\] & \[
\begin{gathered}
\text { Bit } \\
8
\end{gathered}
\] & \[
\begin{aligned}
& \text { 10\% } \\
& \text { Bright }
\end{aligned}
\] & Ref. White & Blanking & Comp. Sync & Analog Output (mV) \\
\hline 1 & 1 & 1 & 1 & 1 & 1 & 1 & 1 & 0 & 1 & 1 & 1 & 0 \\
\hline 1 & 1 & 1 & 1 & 1 & 1 & 1 & 1 & 1 & 1 & 1 & 1 & -71 \\
\hline 1 & 0 & 0 & 0 & 0 & 0 & 0 & 0 & 0 & 1 & 1 & 1 & -320 \\
\hline 0 & 0 & 0 & 0 & 0 & 0 & 0 & 0 & 0 & 1 & 1 & 1 & -637.5 \\
\hline 0 & 0 & 0 & 0 & 0 & 0 & 0 & 0 & 1 & 1 & 1 & 1 & -708.5 \\
\hline X & X & X & X & X & X & X & X & 0 & 0 & 1 & 1 & 0 \\
\hline X & X & X & X & X & X & X & X & 1 & 0 & 1 & 1 & -71 \\
\hline X & X & X & X & X & X & X & X & 0 & 1 & 0 & 1 & -637.50 \({ }^{1}\) \\
\hline X & X & X & X & X & X & X & X & 0 & 1 & 0 & 1 & -690.75 \({ }^{2}\) \\
\hline X & X & X & X & X & X & X & X & 0 & 1 & 0 & 1 & \(-708.50^{3}\) \\
\hline X & X & X & X & X & X & X & X & 0 & 1 & 0 & 1 & \(-779.50^{4}\) \\
\hline X & X & X & X & X & X & X & X & 0 & 1 & 0 & 0 & \(-922.50^{1}\) \\
\hline X & X & X & X & X & X & X & X & 0 & 1 & 0 & 0 & -975.75 \({ }^{2}\) \\
\hline X & X & X & X & X & X & X & X & 0 & 1 & 0 & 0 & \(-993.50^{3}\) \\
\hline X & X & X & X & X & X & X & X & 0 & 1 & 0 & 0 & \(-1064.50^{4}\) \\
\hline X & X & X & X & X & X & X & X & 1 & 1 & 0 & 0 & \(-993.50^{1}\) \\
\hline X & X & X & X & X & \(\mathbf{X}\) & X & X & 1 & 1 & 0 & 0 & \(-1046.75^{2}\) \\
\hline X & X & X & X & X & X & X & X & 1 & 1 & 0 & 0 & \(-1064.50^{3}\) \\
\hline X & X & X & X & X & X & X & X & 1 & 1 & 0 & 0 & \(-1135.50^{4}\) \\
\hline
\end{tabular}

\section*{NOTES}
1. Setup (Pin 21) grounded (0 IRE units).
2. Setup (Pin 21) open (7.5 IRE units).
3. Setup (Pin 21) to -5.2 V through 1 k ( 0 IRE units).
4. Setup (Pin 21) to -5.2 V ( 20 IRE units).

\section*{ORDERING GUIDE}
\begin{tabular}{l|l|l|l}
\hline Device & Temperature Range & Description & \begin{tabular}{l} 
Package \\
Option*
\end{tabular} \\
\hline AD9701BQ & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 22-Pin DIP, Industrial Temperature & Q-22 \\
AD9701SE & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 28-Pin LCC, Extended Temperature & E-28A \\
AD9701SQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 22-Pin DIP, Extended Temperature & Q-22 \\
\hline
\end{tabular}

\footnotetext{
*E = Leadless Ceramic Chip Carrier; \(\mathbf{Q}=\) Cerdip. For outline information see Package Information section.
}

\section*{FEATURES}

100 MSPS Update Rate
ECL/TTL Compatibility
SFDR @ 1 MHz: 70 dBc
Low Glitch Impulse: \(\mathbf{2 8}\) pV-s
Fast.Settling: 27 ns
Low Power: 725 mW
1/2 LSB DNL (B Grade)
40 MHz Multiplying Bandwidth

\section*{APPLICATIONS}

\section*{ATE}

Signal Reconstruction
Arbitrary Waveform Generators
Digital Synthesizers
Signal Generators

\section*{GENERAL DESCRIPTION}

The AD9712B and AD9713B D/A converters are replacements for the AD9712 and AD9713 units which offer improved ac and dc performance. Like their predecessors, they are 12-bit, high speed digital-to-analog converters fabricated in an advanced oxide isolated bipolar process. The AD9712B is an ECLcompatible device featuring update rates of 100 MSPS minimum; the TTL-compatible AD9713B will update at 80 MSPS minimum.

FUNCTIONAL BLOCK DIAGRAM


Designed for direct digital synthesis, waveform reconstruction, and high resolution imaging applications, both devices feature low glitch impulse of 28 pV -s and fast settling times of 27 ns . Both units are characterized for dynamic performance and have excellent harmonic suppression.
The AD9712B and AD9713B are available in 28-pin plastic DIPs and PLCCs, with an operating temperature range of \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\). Both are also available for extended temperature ranges of \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) in cerdips and 28 -pin LCC packages.

\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Parameter (Conditions)} & \multirow[b]{2}{*}{Temp} & \multirow[t]{2}{*}{Test Level} & \multicolumn{3}{|l|}{\[
\begin{gathered}
\text { AD9712B/AD9713B } \\
\text { AN/AP }
\end{gathered}
\]} & \multicolumn{3}{|l|}{\[
\begin{gathered}
\text { AD9712B/AD9713B } \\
\text { BN/BP }
\end{gathered}
\]} & \multicolumn{3}{|l|}{AD9712B/AD9713B SE/SQ} & \multicolumn{3}{|l|}{\[
\begin{gathered}
\text { AD9712B/AD9713B } \\
\text { TE/TQ }
\end{gathered}
\]} & \multirow[b]{2}{*}{Units} \\
\hline & & & Min & Typ & Max & Min & Typ & Max & Min & Typ & Max & Min & Typ & Max & \\
\hline RESOLUTION & & & \multicolumn{3}{|c|}{12} & \multicolumn{3}{|c|}{12} & \multicolumn{3}{|c|}{12} & \multicolumn{3}{|c|}{12} & Bits \\
\hline DC ACCURACY & & & & & & & & & & & & & & & \\
\hline Differential Nonlinearity & \(+25^{\circ} \mathrm{C}\) & I & -1.25 & 1.0 & \(+1.25\) & -0.75 & 0.5 & \(+0.75\) & -1.5 & 1.0 & +1.5 & -1.0 & 0.5 & +1.0 & LSB \\
\hline & Full & VI & -2.0 & & 2.0 & -1.5 & & 1.5 & -2.0 & & 2.0 & -1.5 & & 1.5 & LSB \\
\hline Integral Nonlinearity & \(+25^{\circ} \mathrm{C}\) & I & -1.5 & 1.0 & 1.5 & -1.0 & 0.75 & 1.0 & -1.75 & 1.5 & 1.75 & -1.25 & 1.0 & 1.25 & LSB \\
\hline ("Best Fit" Straight Line) & Full & VI & -2.0 & & 2.0 & -1.75 & & 1.75 & -2.0 & & 2.0 & -1.75 & & 1.75 & LSB \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Parameter (Conditions)} & \multirow[b]{2}{*}{Temp} & \multirow[t]{2}{*}{Test Level} & \multicolumn{3}{|l|}{\[
\begin{gathered}
\text { AD9712B } \\
\text { AN/AP/BN/BP/SE/SQ/TE/TQ }
\end{gathered}
\]} & \multicolumn{3}{|l|}{\[
\begin{gathered}
\text { AD9713B } \\
\text { AN/AP/BN/BP/SE/SQ/TE/TQ }
\end{gathered}
\]} & \multirow[b]{2}{*}{Units} \\
\hline & & & Min & Typ & Max & Min & Typ & Max & \\
\hline \multicolumn{10}{|l|}{INITIAL OFFSET ERROR} \\
\hline Zero-Scale Offset Error & \(+25^{\circ} \mathrm{C}\) & I & & 0.5 & 2.5 & & 0.5 & 2.5 & \(\mu \mathrm{A}\) \\
\hline & Full & VI & & & 5.0 & & & 5.0 & \(\mu \mathrm{A}\) \\
\hline Full-Scale Gain Error \({ }^{1}\) & \(+25^{\circ} \mathrm{C}\) & I & & 1.0 & 5 & & 1.0 & 5 & \\
\hline & Full & VI & & & 8 & & & 8 & \\
\hline Offset Drift Coefficient & \(+25^{\circ} \mathrm{C}\) & V & & 0.01 & & & 0.01 & & \(\mu \mathrm{A} /{ }^{\circ} \mathrm{C}\) \\
\hline \multicolumn{10}{|l|}{REFERENCE/CONTROL AMP} \\
\hline Internal Reference Voltage & \(+25^{\circ} \mathrm{C}\) & I & -1.14 & -1.18 & -1.22 & -1.14 & -1.18 & -1.22 & V \\
\hline & Full & VI & -1.12 & & -1.24 & -1.12 & & -1.24 & \\
\hline Internal Reference Voltage Drift & Full & V & & 50 & & & 50 & & ppm/ \(/{ }^{\circ} \mathrm{C}\) \\
\hline Internal Reference Output Current & Full & IV & -50 & & +500 & -50 & & \(+500\) & \(\mu \mathrm{A}\) \\
\hline Amplifier Input Impedance & \(+25^{\circ} \mathrm{C}\) & V & & 50 & & & 50 & & k \(\Omega\) \\
\hline Amplifier Bandwidth & \(+25^{\circ} \mathrm{C}\) & V & & 300 & & & 300 & & kHz \\
\hline \multicolumn{10}{|l|}{REFERENCE INPUT \({ }^{2}\)} \\
\hline Reference Input Impedance & \(+25^{\circ} \mathrm{C}\) & V & & 3 & & & 3 & & k \(\Omega\) \\
\hline Reference Multiplying Bandwidth \({ }^{3}\) & \(+25^{\circ} \mathrm{C}\) & V & & 40 & & & 40 & & MHz \\
\hline \multicolumn{10}{|l|}{DYNAMIC PERFORMANCE} \\
\hline Full-Scale Output Current \({ }^{4}\) & \(+25^{\circ} \mathrm{C}\) & V & & 20.48 & & & 20.48 & & mA \\
\hline Output Compliance Range & \(+25^{\circ} \mathrm{C}\) & IV & -1.2 & & +2 & -1.2 & & +2 & V \\
\hline Output Resistance & \(+25^{\circ} \mathrm{C}\) & IV & 2.0 & 2.5 & 3.0 & 2.0 & 2.5 & 3.0 & k ת \\
\hline Output Capacitance & \(+25^{\circ} \mathrm{C}\) & V & & 15 & & & 15 & & pF \\
\hline Output Update Rate \({ }^{5}\) & \(+25^{\circ} \mathrm{C}\) & IV & 100 & 110 & & 80 & 100 & & MSPS \\
\hline Output Settling Time ( \(\left.\mathrm{t}_{\text {ST }}\right)^{6}\) & \(+25^{\circ} \mathrm{C}\) & V & & 27 & & & 27 & & ns \\
\hline Output Propagation Delay ( \(\mathrm{tPD}{ }^{7}\) & \(+25^{\circ} \mathrm{C}\) & V & & 6 & & & 7 & & ns \\
\hline Glitch Impulse \({ }^{8}\) & \(+25^{\circ} \mathrm{C}\) & V & & 28 & & & 28 & & pV-s \\
\hline Output Rise Time \({ }^{9}\) & \(+25^{\circ} \mathrm{C}\) & V & & 2 & & & 2 & & ns \\
\hline Output Fall Time \({ }^{9}\) & \(+25^{\circ} \mathrm{C}\) & V & & 2 & & & 2 & & ns \\
\hline \multicolumn{10}{|l|}{DIGITAL INPUTS} \\
\hline Logic " 1 " Voltage & Full & VI & -1.0 & -0.8 & & 2.0 & & & V \\
\hline Logic " 0 " Voltage & Full & VI & & -1.7 & -1.5 & & & 0.8 & V \\
\hline Logic " 1 " Current & Full & VI & & & 20 & & & 20 & \(\mu \mathrm{A}\) \\
\hline Logic " 0 " Current & Full & VI & & & 10 & & & 600 & \(\mu \mathrm{A}\) \\
\hline Input Capacitance & \(+25^{\circ} \mathrm{C}\) & V & & 3 & & & 3 & & pF \\
\hline \multirow[t]{2}{*}{Input Setup Time ( \(\mathrm{t}_{\mathbf{s}}{ }^{10}\)} & \(+25^{\circ} \mathrm{C}\) & IV & 0.5 & -0.3 & & 0.5 & -0.3 & & ns \\
\hline & Full & IV & 0.8 & & & 0.8 & & & ns \\
\hline \multirow[t]{2}{*}{Input Hold Time ( \(\left.\mathrm{t}_{\mathbf{H}}\right)^{11}\)} & \(+25^{\circ} \mathrm{C}\) & IV & 1.8 & 1.2 & & 1.8 & 1.2 & & ns \\
\hline & Full & IV & 2.0 & & & 2.0 & & & ns \\
\hline Latch Pulse Width ( \(\mathrm{t}_{\text {LPW }}\) ) (LOW) & \(+25^{\circ} \mathrm{C}\) & IV & 2.5 & 1.7 & & 2.5 & 1.7 & & ns \\
\hline (Transparent) & Full & & 2.8 & & & 2.8 & & & ns \\
\hline \multicolumn{10}{|l|}{AC LINEARITY \({ }^{12}\)} \\
\hline Spurious-Free Dynamic Range (SFDR) & & & & & & & & & \\
\hline 1.23 MHz ; \(10 \mathrm{MSPS} ; 2 \mathrm{MHz}\) Span & \(+25^{\circ} \mathrm{C}\) & V & & 70 & & & 70 & & dB \\
\hline 5.055 MHz ; \(20 \mathrm{MSPS} ; 2 \mathrm{MHz}\) Span & \(+25^{\circ} \mathrm{C}\) & V & & 72 & & & 72 & & dB \\
\hline 10.1 MHz ; \(50 \mathrm{MSPS} ; 2 \mathrm{MHz}\) Span & \(+25^{\circ} \mathrm{C}\) & V & & 68 & & & 68 & & dB \\
\hline 16 MHz ; 40 MSPS ; 10 MHz Span & \(+25^{\circ} \mathrm{C}\) & V & & 68 & & & 68 & & dB \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Parameter (Conditions)} & \multirow[b]{2}{*}{Temp} & \multirow[t]{2}{*}{Test Level} & \multicolumn{3}{|l|}{\begin{tabular}{l}
AD9712B \\
AN/AP/BN/BP/SE/SQ/TE/TQ
\end{tabular}} & \multicolumn{3}{|l|}{\begin{tabular}{l}
AD9713B \\
AN/AP/BN/BP/SE/SQ/TE/TQ
\end{tabular}} & \multirow[b]{2}{*}{Units} \\
\hline & & & Min & Typ & Max & Min & Typ & Max & \\
\hline \multicolumn{10}{|l|}{POWER SUPPLY \({ }^{13}\)} \\
\hline Positive Supply Current (+5.0 V) & \(+25^{\circ} \mathrm{C}\) & 1 & & & & & 6 & 12 & mA \\
\hline & Full & VI & & & & & & 14 & mA \\
\hline Negative Supply Current (-5.2 V) \({ }^{14}\) & \(+25^{\circ} \mathrm{C}\) & I & & 140 & 178 & & 145 & 184 & mA \\
\hline & Full & VI & & & 183 & & & 188 & mA \\
\hline Nominal Power Dissipation & \(+25^{\circ} \mathrm{C}\) & V & & 728 & & & 784 & & mW \\
\hline Power Supply Rejection Radio (PSRR) \({ }^{15}\) & \(+25^{\circ} \mathrm{C}\) & I & & 30 & 100 & & 30 & 100 & \(\mu \mathrm{A} / \mathrm{V}\) \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Measured as error in ratio of full-scale current to current through \(\mathrm{R}_{\text {SET }}\) ( \(160 \mu \mathrm{~A}\) nominal); ratio is nominally 128.
\({ }^{2}\) Full-scale variations among devices are higher when driving REFERENCE INPUT directly.
\({ }^{3}\) Frequency at which the gain is flat \(\pm 0.5 \mathrm{~dB} ; \mathrm{R}_{\mathrm{L}}=50 \Omega ; 50 \%\) modulation at midscale.
\({ }^{4}\) Based on \(\mathrm{I}_{\mathrm{FS}}=128\left(\mathrm{~V}_{\mathrm{REF}} / \mathrm{R}_{\mathrm{SET}}\right)\) when using internal amplifier.
\({ }^{5}\) Data registered into DAC accurately at this rate; does not imply settling to 12 -bit accuracy.
\({ }^{6}\) Measured as voltage settling at midscale transition to \(\pm 0.024 \% ; \mathrm{R}_{\mathrm{L}}=50 \Omega\).
\({ }^{7}\) Measured as the time between the \(50 \%\) point of the falling edge of LATCH ENABLE and the point where the output signal has left a 1 LSB error band around its previous value.
\({ }^{8}\) Peak glitch impulse is measured as the largest area under a single positive or negative transient.
\({ }^{9}\) Measured with \(\mathrm{R}_{\mathrm{L}}=50 \Omega\) and DAC operating in latched mode.
\({ }^{10}\) Data must remain stable for specified time prior to falling edge of LATCH ENABLE signal.
\({ }^{11}\) Data must remain stable for specified time after rising edge of LATCH ENABLE signal.
\({ }^{12}\) SFDR is defined as the difference in signal energy between the fundamental and worst case spurious frequencies in the output spectrum window, which is centered at the fundamental frequency and covers the indicated span.
\({ }^{13}\) Supply voltages should remain stable within \(\pm 5 \%\) for normal operation.
\({ }^{14} 108 \mathrm{~mA}\) typ on Digital \(-\mathrm{V}_{\mathrm{S}}, 37 \mathrm{~mA}\) typ on Analog \(-\mathrm{V}_{\mathrm{s}}\).
\({ }^{15}\) Measured at \(\pm 5 \%\) of \(+V_{S}\) (AD9713B only) and \(-V_{S}\) (AD9712B or AD9713B) using external reference.
Specifications subject to change without notice.

\section*{ABSOLUTE MAXIMUM RATINGS \({ }^{1}\)}

Positive Supply Voltage ( \(+\mathrm{V}_{\mathrm{S}}\) ) (AD9713B Only) . . . . . + +6 V
Negative Supply Voltage ( \(-\mathrm{V}_{\mathrm{s}}\) ) . . . . . . . . . . . . . . . . -7 V
Analog-to-Digital Ground Voltage Differential . . . . . . . . 0.5 V
Digital Input Voltages ( \(\mathrm{D}_{1}-\mathrm{D}_{12}\), LATCH ENABLE)
AD9712B . . . . . . . . . . . . . . . . . . . . . . . . . 0 V to \(-V_{S}\)
AD9713B . . . . . . . . . . . . . . . . . . . . . -0.5 V to \(+\mathrm{V}_{\mathrm{S}}\)
Internal Reference Output Current . . . . . . . . . . . . . . \(500 \mu \mathrm{~A}\)
Control Amplifier Input Voltage Range . . . . . . . 0 V to -4 V
Control Amplifier Output Current . . . . . . . . . . . . . \(\pm 2.5 \mathrm{~mA}\)
Reference Input Voltage Range ( \(\mathrm{V}_{\mathrm{REF}}\) ) ......... 0 V to \(-\mathrm{V}_{\mathrm{S}}\)
Analog Output Current . . . . . . . . . . . . . . . . . . . . . . 30 mA
Operating Temperature Range
AD9712B/AD9713BAN/AP/BN/BP . . . . . \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
AD9712B/AD9713BSE/SQ/TE/TQ . . . . . . \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
Maximum Junction Temperature \({ }^{2}\)
AD9712B/AD9713BAN/AP/BN/BP . . . . . . . . . . . . \(+150^{\circ} \mathrm{C}\)
AD9712B/AD9713BSE/SQ/TE/TQ . . . . . . . . . . . . \(+175^{\circ} \mathrm{C}\)
Lead Temperature (Soldering, 10 sec ) . . . . . . . . . . . \(+300^{\circ} \mathrm{C}\)
Storage Temperature Range . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)

\section*{NOTES}
\({ }^{1}\) Absolute maximum ratings are limiting values to be applied individually, and beyond which the serviceability of the circuit may be impaired. Functional operability is not necessarily implied. Exposure to absolute maximum rating conditions for an extended period of time may affect device reliability.
\({ }^{2}\) Typical thermal impedances with parts soldered in place: 28 -pin plastic DIP:
 Cerdip: \(\theta_{\mathrm{JA}}=32^{\circ} \mathrm{C} / \mathrm{W}, \theta_{\mathrm{JC}}=10^{\circ} \mathrm{C} / \mathrm{W} ; \mathrm{LCC}: \theta_{\mathrm{JA}}=41^{\circ} \mathrm{C} / \mathrm{W}, \theta_{\mathrm{JC}}=13^{\circ} \mathrm{C} / \mathrm{W}\). No air flow.

ORDERING GUIDE
\begin{tabular}{l|l|l|l}
\hline Model & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Package \\
Description
\end{tabular} & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD9712BAN & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 28-Pin PDIP & N -28 \\
AD9712BBN & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 28-Pin PDIP & \(\mathrm{N}-28\) \\
AD9712BAP & \(-25^{\circ} \mathrm{C}\) t \(+85^{\circ} \mathrm{C}\) & 28-Pin PLCC & P-28A \\
AD9712BBP & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 28-Pin PLCC & P-28A \\
AD9712BSQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 28-Pin Cerdip & \(\mathrm{Q}-28\) \\
AD9712BSE & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 28-Pin LCC & \(\mathrm{E}-28 \mathrm{~A}\) \\
AD9712BTQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 28-Pin Cerdip & \(\mathrm{Q}-28\) \\
AD9712BTE & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 28-Pin LCC & \(\mathrm{E}-28 \mathrm{~A}\) \\
AD9713BAN & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 28-Pin PDIP & \(\mathrm{N}-28\) \\
AD9713BBN & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 28-Pin PDIP & \(\mathrm{N}-28\) \\
AD9713BAP & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 28-Pin PLCC & P-28A \\
AD9713BBP & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 28-Pin PLCC & P-28A \\
AD9713BSQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 28-Pin Cerdip & \(\mathrm{Q}-28\) \\
AD9713BSE & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 28-Pin LCC & \(\mathrm{E}-28 \mathrm{~A}\) \\
AD9713BTQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 28-Pin Cerdip & \(\mathrm{Q}-28\) \\
AD9713BTE & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 28-Pin LCC & \(\mathrm{E}-28 \mathrm{~A}\) \\
\hline
\end{tabular}
*For outline information see Package Information section.

\section*{EXPLANATION OF TEST LEVELS}

\section*{Test Level}

I - \(100 \%\) production tested.
II - \(100 \%\) production tested at \(+25^{\circ} \mathrm{C}\), and sample tested at specified temperatures.
III - Sample tested only.
IV - Parameter is guaranteed by design and characterization testing.
V - Parameter is a typical value only.
VI - All devices are \(100 \%\) tested at \(+25^{\circ} \mathrm{C}\). \(100 \%\) production tested at temperature extremes for extended temperature devices; sample tested at temperature extremes for commercial/industrial devices.

PIN DESCRIPTIONS
\begin{tabular}{|c|c|c|c|c|}
\hline Pin \# & Name & \multicolumn{3}{|l|}{Function} \\
\hline 1-10 & \(\mathrm{D}_{2}-\mathrm{D}_{11}\) & \multicolumn{3}{|l|}{Ten bits of twelve-bit digital input word.} \\
\hline 11 & \(\mathrm{D}_{12}\) (LSB) & \multicolumn{3}{|l|}{Least Significant Bit (LSB) of digital input word. Input Coding vs. Current Output} \\
\hline & & Input Code \(\mathrm{D}_{1}-\mathrm{D}_{12}\) & \(\mathrm{I}_{\text {Out }}(\mathrm{mA})\) & \(\overline{\mathrm{I}}\) OUT \((\mathrm{mA})\) \\
\hline & & \[
\begin{aligned}
& 111111111 \\
& 0000000000
\end{aligned}
\] & \[
\begin{aligned}
& -20.475 \\
& 0
\end{aligned}
\] & \[
\begin{array}{|l|}
\hline 0 \\
-20.475
\end{array}
\] \\
\hline 12 & DIGITAL \(-\mathrm{V}_{\text {S }}\) & \multicolumn{3}{|l|}{One of two negative digital supply pins; nominally -5.2 V.} \\
\hline 13 & ANALOG RETURN & \multicolumn{3}{|l|}{Analog ground return. This point and the reference side of the DAC load resistors should be connected to the same potential (nominally ground).} \\
\hline 14 & \(\mathrm{I}_{\text {OUT }}\) & \multicolumn{3}{|l|}{Analog current output; fuil-scale output occurs with digital inputs at all "1."} \\
\hline 15 & ANALOG - \(\mathrm{V}_{\text {S }}\) & \multicolumn{3}{|l|}{One of two negative analog supply pins; nominally -5.2 V .} \\
\hline 16 & \(\overline{\mathrm{I}_{\text {OUT }}}\) & \multicolumn{3}{|l|}{Complementary analog current output; zero scale output occurs with digital inputs at all "l."} \\
\hline 17 & REFERENCE IN & \multicolumn{3}{|l|}{Normally connected to CONTROL AMP OUT (Pin 18). Direct line to DAC current source network. Voltage changes at this point have a direct effect on the full-scale output value of unit. Full-scale current output \(=128\) (Reference voltage \(/ \mathrm{R}_{\mathrm{SET}}\) ) when using internal amplifier.} \\
\hline 18 & CONTROL AMP OUT & \multicolumn{3}{|l|}{Normally connected to REFERENCE INPUT (Pin 17). Output of internal control amplifier, which provides a temperature-compensated drive level to the current switch network.} \\
\hline 19 & CONTROL AMP IN & \multicolumn{3}{|l|}{\multirow[t]{2}{*}{Normally connected to REFERENCE OUT (Pin 20) if not connected to external reference.}} \\
\hline 20 & REFERENCE OUT & & & \\
\hline 21 & DIGITAL - \(\mathrm{V}_{\text {S }}\) & \multicolumn{3}{|l|}{One of two negative digital supply pins; nominally -5.2 V .} \\
\hline 22 & REFERENCE GROUND & \multicolumn{3}{|l|}{Ground return for the internal voltage reference and amplifier.} \\
\hline 23 & DIGITAL \(+\mathrm{V}_{\text {S }}\) & \multicolumn{3}{|l|}{Positive digital supply pin, used only on the AD9713B; nominally +5 V . No connection to this pin on AD9712B.} \\
\hline 24 & \(\mathrm{R}_{\text {SET }}\) & \multicolumn{3}{|l|}{Connection for external resistance reference. Full-scale current out \(=128\) (Reference voltage \(/ \mathrm{R}_{\mathrm{SET}}\) ) when using internal amplifier. Nominally \(7.5 \mathrm{k} \Omega\).} \\
\hline 25 & ANALOG - \(\mathrm{V}_{\text {S }}\) & \multicolumn{3}{|l|}{One of two negative analog supply pins; nominally -5.2 V .} \\
\hline 26 & LATCH ENABLE & \multicolumn{3}{|l|}{Transparent latch control line. Register is transparent when LATCH ENABLE is LOW.} \\
\hline 27 & DIGITAL GROUND & \multicolumn{3}{|l|}{Digital ground return.} \\
\hline 28 & \(\mathrm{D}_{1}\) (MSB) & \multicolumn{3}{|l|}{Most Significant Bit (MSB) of digital input word.} \\
\hline
\end{tabular}

\section*{PIN CONFIGURATIONS}


DIE LAYOUT AND METALIZATION INFORMATION
Die Dimensions . . . . . . . . . . . . . \(220 \times 196 \times 15( \pm 2)\) mils
Pad Dimensions . . . . . . . . . . . . . . . . . . . . . . . . \(4 \times 4\) mils
Metalization . . . . . . . . . . . . . . . . . . . . . . . . . . Aluminum
Backing . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . None
Substrate Potential . . . . . . . . . . . . . . . . . . . . . . . . . . \(-V_{\text {S }}\)
Passivation . . . . . . . . . . . . . . . . . . . . . . . . . . . . Nitride


\section*{THEORY AND APPLICATIONS}

The AD9712B and AD9713B high speed digital-to-analog converters utilize Most Significant Bit (MSB) decoding and segmentation techniques to reduce glitch impulse and maintain 12-bit linearity without trimming.
As shown in the functional block diagram, the design is based on four main subsections: the Decoder/Driver circuits, the Transparent Latches, the Switch Network, and the Control Amplifier. An internal bandgap reference is also included to allow operation with a minimum of external components.

\section*{Digital Inputs/Timing}

The AD9712B employs single-ended ECL-compatible inputs for data inputs \(\mathrm{D}_{1}-\mathrm{D}_{12}\) and LATCH ENABLE. The internal ECL midpoint reference is designed to match 10 K ECL device thresholds. On the AD9713B, a TTL translator is added at each input; with this exception, the AD9712B and AD9713B are identical.
In the Decoder/Driver section, the four MSBs \(\left(D_{1}-D_{4}\right)\) are decoded to 15 "thermometer code" lines. An equalizing delay is included for the eight Least Significant Bits (LSBs) and LATCH ENABLE. This delay minimizes data skew, and data setup and hold times at the latch inputs; this is important when operating the latches in the transparent mode. Without the delay, skew caused by the decoding circuits would degrade glitch impulse.
The latches operate in their transparent mode when LATCH ENABLE (Pin 26) is at logic level " 0 ." The latches should be used to synchronize data to the current switches by applying a narrow LATCH ENABLE pulse with proper data setup and hold times as shown in the Timing Diagram. An external latch at each data input, clocked out of phase with the Latch Enable, operates the AD9712B/AD9713B in a master slave (edgetriggered) mode. This is the optimum way to operate the DAC because data is always stable at the DAC input. An external latch eases timing constraints when using the converter.
Although the AD9712B/AD9713B chip is designed to provide isolation from digital inputs to the outputs, some coupling of digital transitions is inevitable, especially with TTL or CMOS inputs applied to the AD9713B. Digital feedthrough can be reduced by forming a low-pass filter using a ( \(200 \Omega\) ) series resistor in series with the capacitance of each digital input; this rolls off the slew rate of the digital inputs.

\section*{References}

As shown in the functional block diagram, the internal band-gap reference, control amplifier, and reference input are pinned out for maximum user flexibility when setting the reference.
When using the internal reference, REFERENCE OUT (Pin 20) should be connected to CONTROL AMP IN (Pin 19). CONTROL AMP OUT (Pin 18) should be connected to REFERENCE IN (Pin 17) through a \(20 \Omega\) resistor. A \(0.1 \mu \mathrm{~F}\) ceramic capacitor from Pin 17 to \(-\mathrm{V}_{\mathrm{S}}\) (Pin 15) improves settling by decoupling switching noise from the current sink base line. A reference current cell provides feedback to the control amp by sinking current through \(\mathbf{R}_{\mathbf{S E T}}(\operatorname{Pin} 24)\).

\(t_{H}\) - INPUT HOLD TIME
\(\mathbf{t}_{\text {ST }}\) - OUTPUT SETTLING TIME
t PD \(^{\text {- OUTPUT PROPAGATION DELAY }}\)

Timing Diagram

Full-scale output current is determined by CONTROL AMP IN and \(\mathrm{R}_{\mathrm{SET}}\) according to the equation:
\[
I_{O U T}(F S)=\left(C O N T R O L A M P I N / R_{S E T}\right) \times 128
\]

The internal reference is nominally -1.18 V with a tolerance of \(\pm 3.5 \%\) and typical drift over temperature of \(50 \mathrm{ppm} /{ }^{\circ} \mathrm{C}\). If greater accuracy or better temperature stability is required, an external reference can be utilized. The AD589 reference shown in Figure 1 features \(\pm 10 \mathrm{ppm} /{ }^{\circ} \mathrm{C}\) drift over temperatures from \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\).


Figure 1. Use of AD589 as External Reference
Two modes of multiplying operation are possible with the AD9712B/AD9713B. Signals with small signal bandwidths up to 300 kHz and input swings of 100 mV , or dc signals from -0.6 V to -1.2 V can be applied to the CONTROL AMP input as shown in Figure 2. Because the control amplifier is internally compensated, the \(0.1 \mu \mathrm{~F}\) capacitor at Pin 17 can be reduced to \(0.01 \mu \mathrm{~F}\) to maximize the multiplying bandwidth. However, it should be noted that settling time for changes to the digital inputs will be degraded.


Figure 2. Low Frequency Multiplying Circuit

The REFERENCE IN pin can also be driven directly for wider bandwidth multiplying operation. The analog signal for this mode of operation must have a signal swing in the range of -3.75 V to -4.25 V . This can be implemented by capacitively coupling into REFERENCE IN a signal with a dc bias of -3.75 V to -4.25 V , as shown in Figure 3; or by driving REFERENCE IN with a low impedance op amp whose signal swing is limited to the stated range.

\section*{Outputs}

As indicated earlier, \(\mathrm{D}_{1}-\mathrm{D}_{4}\) (four MSBs) are decoded and drive 15 discrete current sinks. D5 and D6 are binarily weighted; and
tecture reduces frequency domain errors due to glitch impulse.


Figure 3. Wideband Multiplying Circuit
The Switch Network provides complementary current outputs \(\mathrm{I}_{\text {OUT }}\) and \(\overline{\mathrm{I}_{\text {OUT }}}\). These current outputs are based on statistical current source matching which provides 12 -bit linearity without trim. Current is steered to either \(\mathrm{I}_{\mathrm{OUT}}\) or \(\overline{\mathrm{I}}_{\mathrm{OUT}}\) in proportion to the digital input code. The sum of the two currents is always equal to the full-scale output current minus one LSB.
The current output can be converted to a voltage by resistive loading as shown in Figure 4. Both \(\mathrm{I}_{\mathrm{OUT}}\) and \(\overline{\mathrm{I}_{\mathrm{OUT}}}\) should be loaded equally for best overall performance. The voltage which is developed is the product of the output current and the value of the load resistor.

AD9712B/AD9713B


Figure 4. Typical Resistive Load Connection
An operational amplifier can also be used to perform the I to V conversion of the DAC output. Figure 5 shows an example of a circuit which uses the AD9617, a high speed, current feedback amplifier.


Figure 5. IN Conversion Using Current Feedback

DAC current across feedback resistor \(\mathrm{R}_{\mathrm{FB}}\) determines the AD9617 output swing. A current divider formed by \(\mathbf{R}_{\mathrm{L}}\) and \(\mathbf{R}_{\mathrm{FF}}\) limits the current used in the I-to-V conversion, and provides an output voltage swing within the specifications of the AD9617. Current through \(\mathbf{R}_{2}\) provides dc offset at the output of the AD9617. Adjusting the value of \(R_{1}\) adjusts the value of offset current. This offset current is based on the reference of the AD9712B/AD9713B, to avoid coupling noise into the output signal.
The resistor values in Figure 5 provide a 4.096 V swing, centered at ground, at the output of the AD9617 amplifier.

\section*{Power and Grounding}

Maintaining low noise on power supplies and ground is critical for obtaining optimum results with the AD9712B or AD9713B. DACs are most often used in circuits which are predominantly digital. To preserve 12 -bit performance, especially at conversion speeds up to 100 MSPS, special precautions are necessary for power supplies and grounding.

Ideally, the DAC should have a separate analog ground plane. All ground pins of the DAC, as well as reference and analog output components, should be tied directly to this analog ground plane. The DAC's ground plane should be connected to the system ground plane at a single point.
Ferrite beads such as the Stackpole 57-1392 or Amidon FB-43B101, along with high frequency, low-inductance decoupling capacitors, should be used for the supply connections to isolate digital switching currents from the DAC supply pins. Separate isolation networks for the digital and analog supply connections will further reduce supply noise coupling to the output.
Molded socket assemblies should be avoided even when prototyping circuits with the AD9712B or AD9713B. When the DAC cannot be directly soldered into the board, individual pin sockets such as AMP \#6-330808-0 (knock-out end), or \#60330808-3 (open end) should be used. These have much less effect on inter-lead capacitance than do molded assemblies.

\section*{DDS Applications}

Numerically controlled oscillators (NCOs) are digital devices which generate samples of a sine wave. When the NCO is combined with a high performance D/A converter (DAC), the combination system is referred to as a Direct Digital Synthesizer (DDS).
The digital samples generated by the NCO are reconstructed by the DAC and the resulting sine wave is usable in any system which requires a stable, spectrally pure, frequency-agile reference. The DAC is often the limiting factor in DDS applications, since it is the only analog function in the circuit. The AD9712B/ AD9713B D/A converters offer the highest level of performance available for DDS applications.
DC linearity errors of a DAC are the dominant effect in lowfrequency applications and can affect both noise and harmonic content in the output waveform. Differential Nonlinearity (DNL) errors determine the quantization error between adjacent codes, while Integral Nonlinearity (INL) is a measure of how closely the overall transfer function of the DAC compares with an ideal device. Together, these errors establish the limits of phase and amplitude accuracy in the output waveform.


Figure 6. Direct Digital Synthesizer Block Diagram

When the analog frequency \(\left(f_{A}\right)\) is exactly \(f_{C} / N\) and \(N\) is an even integer, the DDS continually uses a small subset of the available DAC codes. The DNL of the converter is effectively the DNL error of the codes used, and is typically worse than the error measured against all available DAC codes. This increase in DNL is translated into higher harmonic and noise levels at the output.

Glitch impulse, often considered a figure of merit in DDS applications, is simply the initial transient response of the DAC as it moves between two output levels. This nonlinearity is commonly associated with external data skew, but this effect is minimized by using the on-board registers of the AD9712B/AD9713B converters (see Digital Inputs/Timing section). The majority of the glitch impulse, shown below, is produced as the current in the R-2R ladder network settles, and is fairly constant over the full-scale range of the DAC. The fast transients which form the glitch impulse appear as high-frequency spurs in the output spectrum.
While it is difficult to predict the effects of glitch on the output waveform, slew rate limitations translate directly into harmonics. This makes slew rate the dominant effect in ac linearity of the DAC. Applications in which the ratio of analog frequency \(\left(f_{A}\right)\) to clock frequency ( \(\mathrm{f}_{\mathrm{C}}\) ) is relatively high will benefit from the high slew rate and low output capacitance of the AD9712B/ AD9713B devices.
Another concern in DDS applications is the presence of aliased harmonics in the output spectrum. Aliased harmonics appear as spurs in the output spectrum at frequencies which are determined by:
\[
M f A \pm N f_{C}
\]
where \(M\) and \(N\) are integers.
The effects of these spurs are most easily observed in applications where \(f_{A}\) is nearly equal to an integer fraction of the clock rate. This condition causes the aliased harmonics to fold near the fundamental output frequency.


Figure 7. AD9712B/AD9713B Glitch Impulse


Figure 8. Rise and Fall Characteristics

\section*{AD9720/AD9721}

\section*{FEATURES}

400 MSPS (ECL)/100 MSPS (TTL) Update Rate
Low Glitch Impulse: \(\mathbf{1 . 5}\) pV-s
Fast Settling: 4.5 ns to \(\mathbf{1 / 2}\) LSB
Low Power: 1.1 W
On-Board Quadrature Logic
for DDS Applications
Differential Clock (ECL)

\section*{APPLICATIONS}

\section*{Direct Digital Synthesis}

Arbitrary Waveform Synthesis
Waveform Reconstruction
High Speed Imaging

\section*{GENERAL DESCRIPTION}

The AD9720 and AD9721 D/A converters are 10-bit, high speed digital-to-analog converters constructed in an oxide isolated
bipolar process. The AD9720 is ECL compatible, and will update up to 400 Msps ; the AD9721 is TTL compatible and will update up to 100 Msps .
Designed for direct digital synthesis (DDS), waveform reconstruction, and high resolution video applications, both devices feature low glitch impulse of 1.5 pV -s and fast settling times of 4.5 ns to \(1 / 2\) LSB.

Both converters are characterized for dynamic performance, and have excellent harmonic suppression and spectral purity in waveform generation applications.
The units are available in 28 -pin DIPs, LCCs and SOICs. Industrial temperature range devices are packaged in plastic for operation from \(-25^{\circ} \mathrm{C}\) to \(+25^{\circ} \mathrm{C}\); extended temperature range devices for operation from \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) are in hermetic ceramic packages. Contact the factory for information about the availability of MIL-STD-883 devices.

FUNCTIONAL BLOCK DIAGRAM AND CONNECTIONS


ELECTRICAL CHARACTERISTICS \(\begin{aligned} & \left(-V_{S}=-5.2 \mathrm{~V} ;+\mathrm{V}_{\mathrm{S}}=+5 \mathrm{~V} \text { [AD9721 only]; Reference Voltage }=-1.25 \mathrm{~V} \text {; } \mathrm{R}_{\mathrm{SET}}=1,960 \Omega \text {, unless otherwise noted) }\right.\end{aligned}\)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Parameter (Conditions)} & \multirow[b]{2}{*}{Temp} & \multirow[t]{2}{*}{\begin{tabular}{l}
Test \\
Level
\end{tabular}} & \multicolumn{3}{|l|}{AD9720BN/BR} & \multicolumn{3}{|l|}{AD9720TE/TQ} & \multicolumn{3}{|l|}{AD9721BN/BR} & \multicolumn{3}{|l|}{AD9721TE/TQ} & \multirow[b]{2}{*}{Units} \\
\hline & & & Min & Typ & Max & Min & Typ & Max & Min & Typ & Max & Min & Typ & Max & \\
\hline RESOLUTION & & & \multicolumn{3}{|c|}{10} & \multicolumn{3}{|c|}{10} & \multicolumn{3}{|c|}{10} & \multicolumn{3}{|c|}{10} & Bits \\
\hline \begin{tabular}{l}
DC ACCURACY \\
Differential Nonlinearity \\
Integral Nonlinearity \\
("Best Fit" Straight Line)
\end{tabular} & \[
\begin{aligned}
& +25^{\circ} \mathrm{C} \\
& \text { Full } \\
& +25^{\circ} \mathrm{C} \\
& \text { Full }
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{I} \\
& \mathrm{VI} \\
& \mathrm{I} \\
& \mathrm{VI}
\end{aligned}
\] & & \[
\begin{aligned}
& 0.25 \\
& 0.5
\end{aligned}
\] & \[
\begin{aligned}
& 0.75 \\
& 1.0 \\
& 1.0 \\
& 1.5
\end{aligned}
\] & & \[
\begin{aligned}
& 0.6 \\
& 0.7
\end{aligned}
\] & \[
\begin{aligned}
& 1.0 \\
& 1.5 \\
& 1.5 \\
& 2.0
\end{aligned}
\] & & \[
\begin{aligned}
& 0.25 \\
& 0.5
\end{aligned}
\] & \[
\begin{aligned}
& 0.75 \\
& 1.0 \\
& 1.0 \\
& 1.5
\end{aligned}
\] & & 0.6
0.7 & \[
\begin{aligned}
& 1.0 \\
& 1.5 \\
& 1.5 \\
& 2.0
\end{aligned}
\] & \[
\begin{array}{|l}
\text { LSB } \\
\text { LSB } \\
\text { LSB } \\
\text { LSB }
\end{array}
\] \\
\hline INITIAL OFFSET ERROR Zero-Scale Offset Error Full-Scale Gain Error \({ }^{1}\) Offset Drift Coefficient & \[
\begin{aligned}
& +25^{\circ} \mathrm{C} \\
& \text { Full } \\
& +25^{\circ} \mathrm{C} \\
& \text { Full } \\
& +25^{\circ} \mathrm{C}
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{I} \\
& \text { VI } \\
& \mathrm{I} \\
& \text { VI } \\
& \mathrm{V}
\end{aligned}
\] & & \[
\begin{aligned}
& 16 \\
& 20 \\
& 2 \\
& \\
& 0.04
\end{aligned}
\] & \[
\begin{aligned}
& 60 \\
& 75 \\
& 15 \\
& 15
\end{aligned}
\] & & \[
\begin{aligned}
& 16 \\
& 20 \\
& 2 \\
& \\
& 0.04
\end{aligned}
\] & \[
\begin{aligned}
& 60 \\
& 75 \\
& 15 \\
& 15
\end{aligned}
\] & & \[
\begin{aligned}
& 16 \\
& 20 \\
& 2 \\
& 0.04
\end{aligned}
\] & \[
\begin{aligned}
& 60 \\
& 75 \\
& 15 \\
& 15
\end{aligned}
\] & & \[
\begin{aligned}
& 16 \\
& 20 \\
& 2 \\
& 0.04
\end{aligned}
\] & \[
\begin{aligned}
& 60 \\
& 75 \\
& 15 \\
& 15
\end{aligned}
\] & \[
\begin{aligned}
& \mu \mathrm{A} \\
& \mu \mathrm{~A} \\
& \% \\
& \% \\
& \mu \mathrm{~A} /{ }^{\circ} \mathrm{C}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
REFERENCE/CONTROL AMP \\
Internal Reference Voltage \\
Internal Reference Voltage Drift Internal Reference Output Current Amplifier Input Impedance Amplifier Bandwidth
\end{tabular} & \[
\begin{aligned}
& +25^{\circ} \mathrm{C} \\
& \text { Full } \\
& \text { Full } \\
& \text { Full } \\
& +25^{\circ} \mathrm{C} \\
& +25^{\circ} \mathrm{C}
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{I} \\
& \mathrm{VI} \\
& \mathrm{~V} \\
& \mathrm{IV} \\
& \mathrm{~V} \\
& \mathrm{~V}
\end{aligned}
\] & \[
\left\lvert\, \begin{aligned}
& -1.15 \\
& -1.15 \\
& -50
\end{aligned}\right.
\] & \[
\begin{aligned}
& -1.25 \\
& 100 \\
& 50 \\
& 1
\end{aligned}
\] & \[
\begin{gathered}
-1.35 \\
-1.35 \\
+500
\end{gathered}
\] & \[
\begin{aligned}
& -1.15 \\
& -1.15 \\
& -50
\end{aligned}
\] & \[
\begin{aligned}
& -1.25 \\
& 100 \\
& \\
& 50 \\
& 1
\end{aligned}
\] & \[
\begin{array}{r}
-1.35 \\
-1.35 \\
+500
\end{array}
\] & \[
\begin{aligned}
& -1.15 \\
& -1.15 \\
& -50
\end{aligned}
\] & \[
\begin{aligned}
& -1.25 \\
& 100 \\
& 50 \\
& 1
\end{aligned}
\] & \[
\begin{aligned}
& -1.35 \\
& -1.35 \\
& +500
\end{aligned}
\] & \[
\begin{aligned}
& -1.15 \\
& -1.15 \\
& -50
\end{aligned}
\] & \[
\begin{aligned}
& -1.25 \\
& 100 \\
& \\
& 50 \\
& 1
\end{aligned}
\] & \[
\begin{array}{r}
-1.35 \\
-1.35 \\
+500
\end{array}
\] & \begin{tabular}{l}
V \\
V \(\mu \mathrm{V} /{ }^{\circ} \mathrm{C}\) \(\mu \mathrm{A}\) \(\mathrm{k} \Omega\) MHz
\end{tabular} \\
\hline \begin{tabular}{l}
REFERENCE INPUT \({ }^{2}\) \\
Reference Input Impedance \\
Reference Multiplying Bandwidth \({ }^{3}\)
\end{tabular} & \[
\left.\begin{aligned}
& +25^{\circ} \mathrm{C} \\
& +25^{\circ} \mathrm{C}
\end{aligned} \right\rvert\,
\] & \[
\mathrm{V}
\] & & \[
\begin{aligned}
& 4.6 \\
& 75
\end{aligned}
\] & & & \[
\begin{aligned}
& 4.6 \\
& 75
\end{aligned}
\] & & & \[
\begin{aligned}
& 4.6 \\
& 75
\end{aligned}
\] & & & \[
\begin{aligned}
& 4.6 \\
& 75
\end{aligned}
\] & & k \(\Omega\) MHz \\
\hline \begin{tabular}{l}
OUTPUT PERFORMANCE \\
Full-Scale Output Current \({ }^{2,4}\) Output Compliance Range \\
Output Resistance \\
Output Capacitance \\
Output Update Rate \\
Voltage Setting Time ( \(1 / 2\) LSB) \({ }^{5}\) \\
Propagation Delay ( \(\left.\mathrm{t}_{\mathrm{PD}}\right)^{6}\) \\
Glitch Impulse \({ }^{7}\) \\
Output Slew Rate \({ }^{8}\) \\
Output Rise Time \({ }^{8}\) \\
Output Fall Time \({ }^{8}\)
\end{tabular} & \(+25^{\circ} \mathrm{C}\)
\(+25^{\circ} \mathrm{C}\)
\(+25^{\circ} \mathrm{C}\)
\(+25^{\circ} \mathrm{C}\)
\(+25^{\circ} \mathrm{C}\)
\(+25^{\circ} \mathrm{C}\)
\(+25^{\circ} \mathrm{C}\)
\(+25^{\circ} \mathrm{C}\)
\(+25^{\circ} \mathrm{C}\)
\(+25^{\circ} \mathrm{C}\)
\(+25^{\circ} \mathrm{C}\) & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{IV} \\
& \mathrm{~V} \\
& \mathrm{v} \\
& \mathrm{~V} \\
& \mathrm{v} \\
& \mathrm{~V} \\
& \mathrm{~V} \\
& \mathrm{~V} \\
& \mathrm{~V} \\
& \mathrm{~V}
\end{aligned}
\] & \[
-1.5
\] & 20.48
210
6
400
4.5
4.0
1.5
1,000
675
470 & +3 & \(-1.5\) & 20.48
210
6
400
4.5
4.0
1.5
1,000
675
470 & +3 & -1.5 & 20.48
210
6
100
4.5
4.5
1.5
1,000
675
470 & +3 & -1.5 & 20.48
210
6
100
4.5
4.5
1.5
1,000
675
470 & +3 & \begin{tabular}{l}
mA \\
V \\
\(\Omega\) \\
pF \\
Msps \\
ns \\
ns \\
pV-s \\
V/us \\
ps \\
ps
\end{tabular} \\
\hline \begin{tabular}{l}
DIGITAL INPUTS \\
Logic " 1 " Voltage Logic "0" Voltage Logic " 1 " Current Logic "0" Current Input Capacitance Input Setup Time \(\left(\mathrm{t}_{\mathrm{s}}\right)^{9}\) Input Hold Time \(\left(\mathrm{t}_{\mathrm{H}}\right)^{10}\) Clock Pulse Width (Low) Clock Pulse Width (High)
\end{tabular} & \[
\begin{aligned}
& \text { Full } \\
& \text { Full } \\
& \text { Full } \\
& \text { Full } \\
& +25^{\circ} \mathrm{C} \\
& +25^{\circ} \mathrm{C} \\
& \text { Full } \\
& +25^{\circ} \mathrm{C} \\
& \text { Full } \\
& +25^{\circ} \mathrm{C} \\
& +25^{\circ} \mathrm{C}
\end{aligned}
\] & \[
\begin{aligned}
& \text { VI } \\
& \text { VI } \\
& \text { VI } \\
& \text { VI } \\
& \text { V } \\
& \text { IV } \\
& \text { IV } \\
& \text { IV } \\
& \text { IV } \\
& \text { IV } \\
& \hline
\end{aligned}
\] & \[
\begin{array}{|c}
-1.0 \\
\\
\\
1.0 \\
1.2 \\
1.6 \\
2.8 \\
1.1 \\
1.4
\end{array}
\] & \[
\begin{aligned}
& 3 \\
& 0.4 \\
& 1.2 \\
& \\
& 0.85 \\
& 0.85
\end{aligned}
\] & \[
\begin{aligned}
& -1.5 \\
& 50 \\
& 2
\end{aligned}
\] & -0.9

1.0
1.2
1.6
2.8
1.1
1.4 & \[
\begin{aligned}
& 3 \\
& 0.4 \\
& 1.2 \\
& \\
& 0.85 \\
& 0.85
\end{aligned}
\] & \[
\begin{aligned}
& -1.6 \\
& 50 \\
& 2
\end{aligned}
\] & \[
\begin{array}{|c}
2.0 \\
\\
1.0 \\
1.2 \\
2.0 \\
2.3 \\
1.0 \\
1.1 \\
\hline
\end{array}
\] & \[
\begin{aligned}
& 3 \\
& 0.5 \\
& 1.25 \\
& 0.85 \\
& 0.85
\end{aligned}
\] & \[
\begin{aligned}
& 0.8 \\
& 400 \\
& 700
\end{aligned}
\] & 2.0
1.0
1.2
2.0
2.3
1.0
1.1 & \[
\begin{aligned}
& 3 \\
& 0.5 \\
& 1.25 \\
& 0.85 \\
& 0.85
\end{aligned}
\] & \[
\begin{aligned}
& 0.8 \\
& 400 \\
& 700
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{~V} \\
& \mu \mathrm{~A} \\
& \mu \mathrm{~A} \\
& \mathrm{pF} \\
& \mathrm{~ns} \\
& \mathrm{~ns} \\
& \mathrm{~ns} \\
& \mathrm{~ns} \\
& \mathrm{~ns} \\
& \mathrm{~ns}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
DYNAMIC PERFORMANCE \\
Spurious-Free Dynamic Range (SFDR) \({ }^{1}\) \\
\(2.02 \mathrm{MHz} ; 100 \mathrm{Msps} ; 2 \mathrm{MHz}\) Span \(25.01 \mathrm{MHz} ; 100 \mathrm{Msps} ; 2 \mathrm{MHz}\) Span \(10.02 \mathrm{MHz} ; 250 \mathrm{Msps} ; 5 \mathrm{MHz}\) Span \(62.54 \mathrm{MHz} ; 250 \mathrm{Msps} ; 5 \mathrm{MHz}\) Span \(70 \mathrm{MHz} ; 220 \mathrm{Msps} ; 10 \mathrm{MHz}\) Span
\end{tabular} & \[
\begin{aligned}
& +25^{\circ} \mathrm{C} \\
& +25^{\circ} \mathrm{C} \\
& +25^{\circ} \mathrm{C} \\
& +25^{\circ} \mathrm{C} \\
& +25^{\circ} \mathrm{C}
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{~V} \\
& \mathrm{~V} \\
& \mathrm{~V} \\
& \mathrm{~V}
\end{aligned}
\] & & \[
\begin{aligned}
& 75 \\
& 66 \\
& 70 \\
& 55 \\
& 70 \\
& \hline
\end{aligned}
\] & & & \[
\begin{aligned}
& 75 \\
& 66 \\
& 70 \\
& 55 \\
& 70 \\
& \hline
\end{aligned}
\] & & & \[
\begin{aligned}
& 75 \\
& 66 \\
& \text { N/A } \\
& \text { N/A } \\
& \text { N/A }
\end{aligned}
\] & & & \[
\begin{aligned}
& 75 \\
& 66 \\
& \text { N/A } \\
& \text { N/A } \\
& \text { N/A }
\end{aligned}
\] & & \[
\begin{aligned}
& \mathrm{dBc} \\
& \mathrm{dBc} \\
& \mathrm{dBc} \\
& \mathrm{dBc} \\
& \mathrm{dBc}
\end{aligned}
\] \\
\hline
\end{tabular}
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Parameter (Conditions)} & \multirow[b]{2}{*}{Temp} & \multirow[t]{2}{*}{Test Level} & \multicolumn{3}{|r|}{AD9720BN/BR} & \multicolumn{3}{|l|}{AD9720TE/TQ} & \multicolumn{3}{|l|}{AD9721BN/BR} & \multicolumn{3}{|l|}{AD9721TE/TQ} & \multirow[b]{2}{*}{Units} \\
\hline & & & Min & Typ & Max & Min & Typ & Max & Min \({ }^{\prime \prime}\) & Typ & Max & Min & Typ & Max & \\
\hline POWER SUPPLY \({ }^{12}\) & & & & & & & & & & & & & & - & \\
\hline Negative Supply Current (-5.2 V) \({ }^{13}\) & \(+25^{\circ} \mathrm{C}\) & I & , & 210 & 280 & & 210 & 280 & & 218 & 290 & & 218 & 290 & mA \\
\hline & Full & VI & & & 290 & & & 290 & & & 300 & & & 300 & mA \\
\hline Positive Supply Current (+5.0 V) & \(+25^{\circ} \mathrm{C}\) & I & & N/A & & & N/A & & & 14 & 30 & & 14 & 30 & mA \\
\hline & Full & VI & & N/A & & & N/A & & & & 30 & & & 30 & mA \\
\hline Nominal Power Dissipation & \(+25^{\circ} \mathrm{C}\) & V & & 1.1 & & & 1.1 & & & 1.2 & & & 1.2 & & W \\
\hline Power Supply Rejection Ratio (PSRR) \({ }^{14}\) & \(+25^{\circ} \mathrm{C}\) & V & & 50 & & & 50 & & & 50 & & & 50 & & \(\mu \mathrm{A} / \mathrm{V}\) \\
\hline
\end{tabular}

NOTES
\({ }^{1}\) Measured as error in ratio of full-scale current to current through \(\mathrm{R}_{\text {SET }}(640 \mu \mathrm{~A}\) nominal); ratio is nominally 32. DAC load is virtual ground.
\({ }^{2}\) Full-scale current variations among devices are higher when driving REFERENCE IN directly.
\({ }^{3}\) Frequency at which a 3 dB change in output of DAC is observed; \(\mathrm{R}_{\mathrm{L}}=50 \Omega ; 100 \mathrm{mV}\) modulation at midscale.
\({ }^{4}\) Based on \(I_{F S}=32\) (CONTROL AMP IN/R \({ }_{\text {SET }}\) ) when using internal control amplifier. DAC load is virtual ground.
\({ }^{5}\) Measured as voltage settling at midscale transition to \(\pm 0.1 \% ; \mathrm{R}_{\mathrm{L}}=50 \Omega\).
\({ }^{6}\) Measured from \(50 \%\) point of rising edge of CLOCK signal to \(1 / 2\) LSB change in output signal.
\({ }^{7}\) Peak glitch impulse is measured as the largest area under a single positive or negative transient.
\({ }^{8}\) Measured with \(\mathrm{R}_{\mathrm{L}}=50 \Omega\) and DAC operating in latched mode.
\({ }^{9}\) Data must remain stable for specified time prior to rising edge of CLOCK.
\({ }^{10}\) Data must remain stable for specified time after rising edge of CLOCK.
\({ }^{11}\) SFDR is defined as the difference in signal energy between the fundamental and worst case spurious frequencies in the output spectrum window, which is centered at the fundamental frequency and covers the indicated span.
\({ }^{12}\) Supply voltages should remain stable within \(\pm 5 \%\) for normal operation.
\({ }^{13} 190 \mathrm{~mA}\) typ on Digital \(-V_{S}, 30 \mathrm{~mA}\) typ on Analog - \(V_{S}\)
\({ }^{14}\) Measured at \(\pm 5 \%\) of \(+\mathrm{V}_{\mathrm{S}}\) (AD9721 only) and \(-\mathrm{V}_{\mathrm{S}}\) (AD9720 or AD9721) using external reference.
Specifications subject to change without notice.

\section*{ABSOLUTE MAXIMUM RATINGS \({ }^{1}\)}

Positive Supply Voltage (+V \({ }^{\text {}}\) ) (AD9721 Only) . . . . . . . +6 V
Negative Supply Voltage ( \(-\mathrm{V}_{\mathrm{S}}\) ) (AD9720 and AD9721) . -7 V
Digital Input Voltages ( \(\mathrm{D}_{1}-\mathrm{D}_{10}\), CLOCK, \(\overline{\text { CLOCK }}\) )
\[
\text { AD9720 .. . . . . . . . . . . . . . . . . . . . . . . . . . } 0 \text { V to }-V_{S}
\]

AD9721 . . . . . . . . . . . . . . . . . . . . . . . . - 0.5 V to \(+\mathrm{V}_{\mathrm{s}}\)
Internal Reference Output Current . . . . . . . . . . . . . . \(500 \mu \mathrm{~A}\)
Control Amplifier Input Voltage Range . . . . . . . 0 V to -4 V
Control Amplifier Output Current . . . . . . . . . . . . . \(\pm 2.5 \mathrm{~mA}\)
Reference Input Voltage Range ( \(\mathrm{V}_{\mathrm{REF}}\) ) . . . . . . . 0 V to \(-\mathrm{V}_{\mathrm{s}}\)
Analog Output Current . . . . . . . . . . . . . . . . . . . . . . 30 mA
Operating Temperature Range
AD9720/AD9721BN/BR . . . . . . . . . . . . . \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
AD9720/AD9721TE/TQ . . . . . . . . . . . . \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
Maximum Junction Temperature \({ }^{2}\)
AD9720/AD9721BN/BR . . . . . . . . . . . . . . . . . . . + \(150^{\circ} \mathrm{C}\)
AD9720/AD9721TE/TQ . . . . . . . . . . . . . . . . . . . \(+175^{\circ} \mathrm{C}\)
Lead Temperature (Soldering, 10 sec ) . . . . . . . . . . . \(+300^{\circ} \mathrm{C}\)
Storage Temperature Range . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
NOTES
\({ }^{1}\) Absolute maximum ratings are limiting values to be applied individually, and beyond which the serviceability of the circuit may be impaired. Functional operability is not necessarily implied. Exposure to absolute maximum rating conditions for an extended period of time may affect device reliability.
\({ }^{2}\) Typical thermal impedances: 28 -pin plastic DIP: \(\theta_{\mathrm{JA}}=37^{\circ} \mathrm{C} / \mathrm{W}, \theta_{\mathrm{JC}}=10^{\circ} \mathrm{C} / \mathrm{W}\); 28-pin LCC: \(\theta_{\mathrm{JA}}=41^{\circ} \mathrm{C} / \mathrm{W}, \theta_{\mathrm{JC}}=13^{\circ} \mathrm{C} / \mathrm{W} ; 28\)-pin SOIC: \(\theta_{\mathrm{JA}}=46^{\circ} \mathrm{C} / \mathrm{W}\), \(\theta_{\mathrm{JC}}=10^{\circ} \mathrm{C} / \mathrm{W}\); Cerdip: \(\theta_{\mathrm{JA}}=35^{\circ} \mathrm{C} / \mathrm{W}, \theta_{\mathrm{JC}}=10^{\circ} \mathrm{C} / \mathrm{W}\). Soldered to board; no air flow.

ORDERING GUIDE
\begin{tabular}{l|l|l|l}
\hline Model & \begin{tabular}{l} 
Temperature \\
Range
\end{tabular} & \begin{tabular}{l} 
Package \\
Description
\end{tabular} & \begin{tabular}{l} 
Package \\
Option
\end{tabular} \\
\hline AD9720BN & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 28 -Pin PDIP & N-28 \\
AD9720BR & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 28 -Pin SOIC & R-28 \\
AD9720TE & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 28 -Pin LCC & E-28A \\
AD9720TQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 28 -Pin Cerdip & Q-28 \\
AD9721BN & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 28 -Pin PDIP & N-28 \\
AD9721BR & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 28 -Pin SOIC & R-28 \\
AD9721TE & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 28 -Pin LCC & E-28A \\
AD9721TQ & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 28-Pin Cerdip & Q-28 \\
\hline
\end{tabular}
*For outline information see Package Information section.*

\section*{EXPLANATION OF TEST LEVELS}

\section*{Test Level}

I - \(100 \%\) production tested.
II - \(100 \%\) production tested at \(+25^{\circ} \mathrm{C}\), and sample tested at specified temperatures.
III - Sample tested only.
IV - Parameter is guaranteed by design and characterization testing.
V - Parameter is a typical value only.
VI - All devices are \(100 \%\) tested at \(+25^{\circ} \mathrm{C} .100 \%\) production tested at temperature extremes for extended temperature devices; sample tested at temperature extremes for commercial/industrial devices.

DIE LAYOUT AND MECHANICAL INFORMATION
Die Dimensions . . . . . . . . . . . . . \(199 \times 165 \times 15( \pm 2)\) mils
Pad Dimensions . . . . . . . . . . . . . . . . . . . . . . . . \(4 \times 4\) mils
Metalization . . . . . . . . . . . . . . . . . . . . . . . . . . Aluminum
Backing . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . None
Substrate Potential . . . . . . . . . . . . . . . . . . . . . . . . . . - V
Passivation
Nitride
\begin{tabular}{|c|c|c|}
\hline \begin{tabular}{l}
DIP \\
Pin \#
\end{tabular} & Name & Function \\
\hline 1 & \(\mathrm{D}_{1}\) (MSB) & Most Significant Bit (MSB) of digital input word. \\
\hline 2-9 & \(\mathrm{D}_{2}-\mathrm{D}_{9}\) & Eight of 10 digital input bits. Digital inputs are 10K ECL compatible for AD9720; TTL compatible for AD9721. See coding table elsewhere. \\
\hline 10 & \(\mathrm{D}_{10}\) (LSB) & \begin{tabular}{l}
Least Significant Bit (LSB) of digital input word. \\
Input Coding vs. Current Output
\[
\begin{array}{lll}
\text { Input Code } \mathrm{D}_{1}-\mathrm{D}_{10} & \mathrm{I}_{\mathrm{OUT}}(\mathrm{~mA}) & \overline{\mathrm{I}_{\mathrm{OUT}}}(\mathrm{~mA}) \\
1111111111 & -20.48 & 0 \\
0000000000 & 0 & -20.48
\end{array}
\]
\end{tabular} \\
\hline 11 & CLOCK & Edge-triggered latch enable signal for on-board registers. 10K ECL compatible for AD9720. TTL compatible for AD9721. Register loads data on rising edge of CLOCK signal; must be driven in conjunction with \(\overline{\text { CLOCK }}\). \\
\hline 12 & \(\overline{\text { CLOCK }}\) NC & Complementary edge-triggered latch enable signal for on-board registers. 10K ECL compatible for AD9720; not connected (NC) for AD9721. \\
\hline 13 & INVERT & Normally connected to logic LOW; inverters are transparent in this mode. Logic High inverts the 9 LSBs ( \(\mathrm{D}_{2}-\mathrm{D}_{10}\) ) when the MSB is LOW. No internal pull-down resistor. \\
\hline 14 & DIGITAL \(-\mathrm{V}_{\mathrm{S}} /+\mathrm{V}_{\mathbf{S}}\) & One of three digital supply pins; nominally -5.2 V for AD9720; +5 V for AD9721. \\
\hline 15 & GROUND & Converter ground return. \\
\hline 16 & DIGITAL - \(\mathrm{V}_{\text {S }}\) & One of three negative digital supply pins; nominally -5.2 V. \\
\hline 17 & \(\mathbf{R}_{\text {SET }}\) & Connection for external resistance reference; nominally \(1,960 \Omega\). Full-scale current out \(=32 \times\) (CONTROL AMP IN/R \(\mathbf{R E T}_{\text {SET }}\) ) when using internal amplifier. DAC load is virtual ground. \\
\hline 18 & GROUND & Converter ground return. \\
\hline 19 & ANALOG RETURN & Analog current return. This point and the reference side of the DAC load resistors should be connected to the same potential (nominally ground). \\
\hline 20 & \(\mathrm{I}_{\text {OUT }}\) & Analog current output; full-scale output occurs with digital inputs at all " 1 ." With external load resistor, output voltage \(=I_{\text {OUT }} \times\left(R_{\text {LOAD }} \| R_{\text {INTERNAL }}\right) . R_{\text {INTERNAL }}\) is nominally \(210 \Omega\). \\
\hline 21 & \(\overline{\mathrm{I}}\) OUT & Complementary analog current output; zero-scale output occurs with digital inputs at all " 1 ." \\
\hline 22 & ANALOG - \(\mathrm{V}_{\text {S }}\) & Negative analog supply; nominally -5.2 V . \\
\hline 23 & REFERENCE IN & Normally connected to CONTROL AMP OUT (Pin 24). Direct line to DAC current source network. Voltage changes (noise) at this point have a direct effect on the full-scale output current of DAC. Full-scale current output \(=32 \times\left(\right.\) CONTROL AMP \(\left.I N / R_{S E T}\right)\) when using internal amplifier. DAC load is virtual ground. \\
\hline 24 & CONTROL AMP OUT & Normally connected to REFERENCE INPUT (Pin 23). Output of internal control amplifier, which provides a reference for the current switch network. \\
\hline 25 & REFERENCE OUT & Normally connected to CONTROL AMP IN (Pin 26). Internal voltage reference, nominally \(\mathbf{- 1 . 2 5} \mathrm{V}\). \\
\hline 26 & CONTROL AMP IN & Normally connected to REFERENCE OUT (Pin 25) if not connected to external reference. \\
\hline 27 & DIGITAL - \(\mathrm{V}_{\text {S }}\) & One of three negative digital supply pins; nominally -5.2 V. \\
\hline 28 & GROUND & Converter ground return. \\
\hline
\end{tabular}


Pinouts (SOIC Pin Numbering is Same as DIP)


AD9720/AD9721 Timing Diagram

\section*{THEORY AND APPLICATIONS}

The AD9720/AD9721 high speed digital-to-analog converters utilize Most Significant Bit (MSB) decoding and segmentation techniques to reduce glitch impulse and maintain 10-bit linearity without trimming.
As shown in the functional block diagram, the design is based on four main subsections: the Decoder/Driver circuits, the Edge Triggered Data Register, the Switch Network, and the Control Amplifier. An internal bandgap reference is also included to allow operation with a minimum of external components. The block labeled "Inverters" is transparent in normal operation, but can be used to minimize the external components requirements in DDS applications using the AD9950, a 300 Msps phase accumulator (see AD9950 data sheet).

\section*{Digital Inputs/Timing}

The AD9720 employs single-ended ECL-compatible inputs for data inputs \(\mathrm{D}_{1}-\mathrm{D}_{10}\) and the differential clock signals CLOCK and \(\overline{\text { CLOCK }}\). The internal ECL midpoint reference is designed to match 10K ECL device thresholds. On the AD9721, a TTL translator is added at each input and the clock becomes single ended; with these exceptions, the AD9720 and AD9721 are identical. (NOTE: Pin 14 is \(+V_{S}\) on AD9721; \(-V_{S}\) on AD9720.)
In the Decoder/Driver section, the four MSBs \(\left(D_{1}-D_{4}\right)\) are decoded to 15 "thermometer code" lines. An equalizing delay is included for the six Least Significant Bits (LSBs) and the clock signals. This delay minimizes data skew and data setup and hold times at the register inputs.

The on-board register is rising-edge-triggered and should be used to synchronize data to the current switches by applying a pulse with proper data set-up and hold times as shown in the timing diagram.

Although the AD9720/AD9721 chip is designed to provide isolation from digital inputs to the outputs, some coupling of digital transitions is inevitable, especially with TTL or CMOS inputs applied to the AD9721. Digital feedthrough can be reduced by forming a low-pass filter using a resistor in series with the capacitance of each digital input; this rolls off the slew rate of the digital inputs.

\section*{References}

As shown in the functional block diagram, the internal band-gap reference, control amplifier, and reference input are pinned out for maximum user flexibility when setting the reference.
When using the internal reference, REFERENCE OUT (Pin 25) should be connected to CONTROL AMP IN (Pin 26). CON-
TROL AMP OUT (Pin 24) should be connected to REFERENCE IN (Pin 23). A \(0.1 \mu \mathrm{~F}\) ceramic capacitor from Pin 23 to ANALOG \(-\mathrm{V}_{\mathrm{S}}\) ( \(\operatorname{Pin} 22\) ) improves settling by decoupling switching noise from the current sink base line. A reference current cell provides feedback to the control amp by sinking current through \(\mathbf{R}_{\text {SET }}\) (Pin 17).
Full-scale output current is determined by CONTROL AMP IN and \(\mathrm{R}_{\mathrm{SET}}\) according to the equation:
\[
I_{O U T}(F S)=\left(C O N T R O L A M P I N / R_{S E T}\right) \times 32
\]

The internal reference is nominally -1.25 V with a tolerance of \(\pm 8 \%\) and typical drift over temperature of \(100 \mathrm{ppm} /{ }^{\circ} \mathrm{C}\). If greater accuracy or better temperature stability is required, an external reference can be utilized. The AD589 reference features \(\pm 10 \mathrm{ppm} /{ }^{\circ} \mathrm{C}\) drift over temperatures from \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\).

Two modes of multiplying operation are possible with the AD9720/9721. Signals with bandwidths up to 1 MHz and input swings from -0.6 V to -1.2 V can be applied to the CON TROL AMP input as shown in Figure 1. Because the control amplifier is internally compensated, the \(0.1 \mu \mathrm{~F}\) capacitor discussed above can be reduced to maximize the multiplying bandwidth. However, it should be noted that settling time for changes to the digital inputs will be degraded.


Figure 1. Low Frequency Multiplying Circuit
The REFERENCE IN pin can also be driven directly for wider bandwidth multiplying operation. The analog signal for this mode of operation must have a signal swing in the range of -3.3 V to -4.25 V . This can be implemented by capacitively coupling into REFERENCE IN a signal with a dc bias of -3.3 V ( \(\mathrm{I}_{\mathrm{OUT}} \sim 22.5 \mathrm{~mA}\) ) to \(-4.25 \mathrm{~V}\left(\mathrm{I}_{\mathrm{OUT}} \sim 3 \mathrm{~mA}\right)\), as shown in Figure 2, or by driving REFERENCE IN with a low impedance op amp whose signal swing is limited to the stated range.


Figure 2. Wideband Multiplying Circuit

\section*{Outputs}

The Switch Network provides complementary current outputs \(\mathrm{I}_{\text {OUT }}\) and \(\overline{\mathrm{I}_{\text {OUT }}}\). The design of the AD9720/AD9721 is based on statistical current source matching which provides 10 -bit linearity without trim. Current is steered to either \(\mathrm{I}_{\text {OUT }}\) or \(\overline{\mathrm{I}_{\mathrm{OUT}}}\) in proportion to the digital input code. The sum of the two currents is always equal to the full-scale output current minus one LSB.

The current output can be converted to a voltage by resistive loading as shown in the block diagram. Both \(\mathrm{I}_{\mathrm{OUT}}\) and \(\overline{\mathrm{I}_{\mathrm{OUT}}}\) should be loaded equally for best overall performance. The voltage which is developed is the product of the output current and the value of the load resistor.

An operational amplifier can also be used to perform the I to V conversion of the DAC output. Figure 3 shows an example of a circuit which uses the AD9617, a high speed, current feedback amplifier. The resistor values in Figure 3 provide a 4.096 V swing, centered at ground, at the output of the AD9617 amplifier.


Figure 3. I/V Conversion Using Current Feedback Amp

\section*{DDS Applications}

The performance characteristics of the AD9720/AD9721 make it ideally suited for direct digital synthesis (DDS) and other waveform generation applications. Since the aliased distortion of the DAC collects around the fundamental when generating frequencies which are nearly integer fractions of the clock rate, these are often considered worst case conditions.
Please contact the factory for information concerning the availability of an evaluation board or for additional characterization data.


Figure 4. AD9720 Glitch Impulse


Figure 5. Typical Output Spectrum


Figure 6. Typical Output Spectrum


Figure 9. Typical Output Spectrum


Figure 7. Typical Output Spectrum


Figure 8. Typical Output Spectrum


Figure 10. Typical Output Spectrum


Figure 11. Direct Digital Synthesis System Diagram

\section*{FEATURES}

5ns Settling Time
100MSPS Update Rate
20mA Output Current
ECL-Compatible
40MHz Multiplying Mode

\section*{APPLICATIONS}

Raster Scan \& Vector Graphic Displays
High Speed Waveform Generation Digital VCOs
Ultra-Fast Digital Attenuators

\section*{GENERAL DESCRIPTION}

The Analog Devices AD9768SD D/A converter is a monolithic current-output converter which can accept 8 bits of ECL-level digital input voltages and convert them into analog signals at, update rates as high as 100 MSPS . In addition to its use as a standard D/A converter, it can also be utilized as a two-quadrant multiplying \(\mathrm{D} / \mathrm{A}\) at multiplying bandwidths as high as 40 MHz .

An inherently low glitch design is used, and the complementary current outputs are suitable for driving transmission lines directly. Nominal full-scale output is 20 mA , which corresponds to a 1 volt drop across a \(50 \Omega\) load, or \(\pm 1\) volt across \(100 \Omega\) returned to +1 volt. The actual output current is determined by the on-chip reference voltage \(\left(\mathrm{V}_{\text {REF }} \approx-1.26 \mathrm{~V}\right)\) and an external current setting resistor, \(\mathrm{R}_{\mathrm{SET}}\).

Full-scale output current Iout with digital " 1 " at all inputs is calculated with the equation:
\[
I_{\text {OUT }}=4 \times \frac{V_{\text {RET }}-V_{\text {REF }}}{R_{\text {SET }}}
\]

The setting resistor \(\mathrm{R}_{\text {SET }}\) and the output load resistor should both have low temperature coefficients. A complementary \(\overline{I_{\text {OUT }}}\) is also provided.

\section*{AD9768JD/SD PIN CONNECTIONS}


This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

FUNCTIONAL BLOCK DIAGRAM


The reference voltage source is a modified bandgap type and is nominally -1.26 volts. This reference supply requires no external regulation. To reduce the possibility of noise generation and/or instability, pin 15 (REFERENCE OUT) can be decoupled using a high-quality ceramic chip capacitor. Stabilization of the internal loop amplifier is by a single capacitor connected from pin 17 (COMPENSATION) to ground. The minimum value for this capacitor is 3900 pF , although a \(0.01 \mu \mathrm{~F}\) ceramic chip capacitor is recommended.

The incredible speed characteristics of the AD9768SD D/A converter make it attractive for a wide range of high speed applications. The ability of the unit to operate as a two-quadrant multiplying \(\mathrm{D} / \mathrm{A}\) converter adds another dimension to its usefulness and makes the AD9768SD a truly versatile device.

\section*{AD9768SE PIN CONNECTIONS}

\begin{tabular}{|c|c|c|}
\hline Parameter & Unit & AD9768SJD/SD/SE \\
\hline RESOLUTION(FS = FULL SCALE) & Bits & 8 \\
\hline LSB WEIGHT (CURRENT) & \(\mu \mathrm{A}\) & 78 \\
\hline \multicolumn{3}{|l|}{ACCURACY \({ }^{1}\)} \\
\hline Differential Nonlinearity & \(\pm \% \mathrm{FS}\) & 0.2 \\
\hline Integral Nonlinearity & \(\pm \% \mathrm{FS}\) & 0.2 \\
\hline Monotonicity & & Guaranteed \\
\hline Zero Offset (Initial) & \(\mu \mathrm{A}\) & 60 \\
\hline \multicolumn{3}{|l|}{TEMPERATURECOEFFICIENTS} \\
\hline Zero Offset & ppm/ \({ }^{\circ} \mathrm{C}\) & 1.5 \\
\hline Reference Voltage( -1.26 V ) & \(\mathrm{ppm} /{ }^{\circ} \mathrm{C}\) & 70 \\
\hline \multicolumn{3}{|l|}{DIgItal Data inputs} \\
\hline Logic Compatibility & & ECL \\
\hline \multirow[t]{2}{*}{Logic Voltage Levels " 1 " =} & V & -0.9 \\
\hline & V & -1.7 \\
\hline Coding & \multicolumn{2}{|l|}{Binary (BIN) \(=\) Unipolar Out} \\
\hline \multicolumn{3}{|l|}{OUTPUT} \\
\hline Current (Unipolar) FS & mA (max) & 2 to 20(30) \\
\hline \multicolumn{3}{|l|}{Iout(@Pin 13)} \\
\hline All Digital "1" Input & mA & 20 \\
\hline Ali Digital "0" Input & mA & 0 \\
\hline \multicolumn{3}{|l|}{\(\overline{\mathrm{I}_{\text {Out }}}\) (@Pin 14)} \\
\hline All Digital "1"Input & mA & 0 \\
\hline All Digital "0" Input & mA & 20 \\
\hline \multirow[t]{2}{*}{Compliance} & V (Pin 13) & -0.7 to + 3.0 \\
\hline & V(Pin 14) & -1.1 to \(\mathbf{3} .0\) \\
\hline Impedance & \(\Omega( \pm 15 \%)\) & 750 \\
\hline \multicolumn{3}{|l|}{SPEED PERFORMANCE} \\
\hline Settling Time (to \(0.2 \% \mathrm{FS})^{2}\) & ns & 5 \\
\hline Slew Rate & V/us & 400 \\
\hline Update Rate & MSPS & 100 \\
\hline Rise Time & ns & 1.8 \\
\hline Glitch Energy & pV-sec & 200 \\
\hline \multicolumn{3}{|l|}{REFERENCE} \\
\hline Internal, Monolithic \({ }^{3}\) & v & -1.26 \\
\hline \multicolumn{3}{|l|}{External, Variable \({ }^{4}\)} \\
\hline Voltage-Multiplying Mode & V (max) & 0to-1.1(-2) \\
\hline Current-Multiplying Mode & \(\mathrm{mA}^{\text {(max }}\) ) & 0to-5(-7.5) \\
\hline \multicolumn{3}{|l|}{VOLTAGE-MULTIPLYING MODE \({ }^{4}\) (See Figure 2)} \\
\hline \(\mathrm{V}_{\mathrm{M}}\) Range (at Pin 16) & v & \(\pm 0.5\) \\
\hline \(\mathrm{V}_{\mathrm{M}}\) Center & V & -0.6 \\
\hline Resistance (at Pin 16) & k \(\Omega\) & 800 \\
\hline \multirow[t]{4}{*}{Transfer Function-} & \multicolumn{2}{|l|}{Measured at Pin 13; Digital "0" Applied to Bits 1-8:} \\
\hline & \multicolumn{2}{|l|}{} \\
\hline & \multicolumn{2}{|l|}{\begin{tabular}{l}
\(-1.1 \mathrm{~V}_{\mathrm{M}}\) Input \(=0 \mathrm{~mA} \mathrm{I}_{\text {Out }}\) \\
Measured at Pin 13; Digital "1" Applied
\end{tabular}} \\
\hline & \multicolumn{2}{|r|}{\(-0.1 \mathrm{~V}_{\mathrm{M}}\) Input \(=1 \mathrm{~mA} \mathrm{I}_{\text {Out }}\)} \\
\hline Large Signal Bandwidth ( -3 dB Point) & kHz & 250 \\
\hline
\end{tabular}



AD9768SD D/A Schematic

\section*{FEATURES}

4 Complete 12-Bit D/A Functions
Double-Buffered Latches
Simultaneous Update of All DACs Possible
\(\pm 5\) V Output Range
High Stability Bandgap Reference
Monolithic BiMOS Construction
Guaranteed Monotonic over Temperature
3/4 LSB Linearity Guaranteed over Temperature
\(4 \mu \mathrm{~s}\) max Settling Time to 0.01\%
Operates with \(\pm 12\) V Supplies
Low Power: \(\mathbf{7 2 0} \mathbf{~ m W}\) max Including Reference
TTL/5 V CMOS Compatible Logic Inputs
8-Bit Microprocessor Interface
24-Pin PDIP or 28-Lead PLCC Package

\section*{PRODUCT DESCRIPTION}

The AD75004 contains four complete, voltage output, 12-bit digital-to-analog converters, a high stability bandgap reference, and double-buffered input latches on a single chip. The converters use 12 precision high speed bipolar current steering switches and laser-trimmed thin-film resistor networks to provide fast settling time and high accuracy.
Microprocessor compatibility is achieved by the on-chip double-buffered latches. The design of the input latches allows direct interface to 8 -bit buses. The 12 bits of data from the first rank of latches can then be transferred to the second rank, avoiding generation of spurious analog output values. The latch responds to strobe pulses as short as 50 ns , allowing use with fast microprocessors.

The functional completeness and high performance of the AD75004 results from a combination of advanced switch design, the BiMOS II fabrication process, and proven laser trimming technology. BiMOSII is an epitaxial BiCMOS process optimized for analog and converter functions. The AD75004 is trimmed at the wafer level and is specified to \(\pm 1 / 2\) LSB maximum linearity error at \(25^{\circ} \mathrm{C}\) and \(\pm 3 / 4 \mathrm{LSB}\) over the full operating temperature range. The on-chip output amplifiers provide an output range of \(\pm 5 \mathrm{~V}\), with 1 LSB equal to 2.44 mV .

FUNCTIONAL BLOCK DIAGRAM


The bandgap reference on the chip has low noise, long term stability and temperature drift characteristics comparable to discrete reference diodes. The absolute value of the reference is laser trimmed to +5.00 V with \(0.6 \%\) maximum error. Its temperature coefficient is also laser trimmed.
Typical full-scale gain TC is \(15 \mathrm{ppm} /{ }^{\circ} \mathrm{C}\). With guaranteed monotonicity over the full temperature range, the AD75004 is well suited for wide temperature range performance.
\begin{tabular}{|c|c|c|c|c|c|}
\hline Parameter & Symbol & Min & Typ & Max & Units \\
\hline ```
DIGITAL INPUTS (D0-D7, A0-A3, \(\overline{\mathrm{CS}}, \overline{\mathrm{W}}\) )
    Logic Levels (TTL Compatible)
        Input Voltage, Logic " 1 "
        Input Voltage, Logic "0"
        Input Current, \(\mathrm{V}_{\mathrm{IH}}=5.5 \mathrm{~V}\)
        Input Current, \(\mathrm{V}_{\mathrm{IL}}=0.8 \mathrm{~V}\)
    Input Capacitance
``` & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{IH}} \\
& \mathrm{~V}_{\mathrm{IL}} \\
& \mathrm{I}_{\mathrm{IH}} \\
& \mathrm{I}_{\mathrm{IL}}
\end{aligned}
\] & \[
2.0
\] & & \[
\begin{aligned}
& 5.5 \\
& 0.8 \\
& 10 \\
& 10 \\
& 10
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{~V} \\
& \mu \mathrm{~A} \\
& \mu \mathrm{~A} \\
& \mathrm{pF}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
ACCURACY \\
Resolution \\
Integral Linearity Error \\
Integral Linearity Error, \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) \\
Differential Linearity Error \\
Differential Linearity Error, \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) \\
Gain (Full-Scale) Error \({ }^{1}\) \\
Gain Error Drift, \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}{ }^{1}\) \\
Bipolar Zero Error \({ }^{1}\) \\
Bipolar Zero Error Drift, \(\mathrm{T}_{\min }\) to \(\mathrm{T}_{\max }{ }^{1}\)
\end{tabular} & & Guara & \[
\begin{aligned}
& \pm 1 / 4 \\
& \pm 1 / 2 \\
& \pm 1 / 2 \\
& \text { eed } M \\
& \pm 2 \\
& \pm 15 \\
& \pm 1 \\
& \pm 3
\end{aligned}
\] & \begin{tabular}{l}
12 \\
\(\pm 1 / 2\) \\
\(\pm 3 / 4\) \\
\(\pm 3 / 4\) \\
notonic \\
\(\pm 10\) \\
\(\pm 30\) \\
\(\pm 2\) \\
\(\pm 7\)
\end{tabular} & \begin{tabular}{l}
Bits \\
LSB \\
LSB \\
LSB \\
LSB \\
ppm \(/{ }^{\circ} \mathrm{C}\) \\
LSB \\
ppm \(/{ }^{\circ} \mathrm{C}\)
\end{tabular} \\
\hline \begin{tabular}{l}
CHANNEL-TO-CHANNEL MISMATCH \\
Integral Linearity Error Gain Error \({ }^{1}\) Bipolar Zero Error \({ }^{1}\)
\end{tabular} & & & \[
\begin{aligned}
& \pm 1 / 2 \\
& \pm 1 \\
& \pm 1
\end{aligned}
\] & \[
\begin{aligned}
& \pm 1 \\
& \pm 4 \\
& \pm 2
\end{aligned}
\] & \[
\begin{aligned}
& \text { LSB } \\
& \text { LSB } \\
& \text { LSB }
\end{aligned}
\] \\
\hline \begin{tabular}{l}
DYNAMIC PERFORMANCE \\
Settling Time to \(\pm 0.01 \%\) of FSR for FSR Change, \(2 \mathrm{k} \Omega \| 500 \mathrm{pF}\) Load Slew Rate, \(2 \mathrm{k} \Omega \| 500 \mathrm{pF}\) Load Digital Input Crosstalk (Static) \({ }^{2}\)
\end{tabular} & & 5 & & 4
\[
-50
\] & \[
\underset{\mathrm{V} / \mu \mathrm{s}}{\mu \mathrm{~s}}
\]
\[
\mathrm{dB}
\] \\
\hline ANALOG OUTPUTS Full-Scale Range (FSR) Output Current Short Circuit Limit Curren & \(\mathrm{V}_{\text {OUT }}\) \(\mathrm{I}_{\text {out }}\) & \(\pm 5\) & \(\pm 5\) & & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{~mA} \\
& \mathrm{~mA}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
VOLTAGE REFERENCE \\
Reference Output Voltage \\
Temperature Coefficient Reference Output Current \({ }^{3}\) \\
Reference Input Voltage Reference Input Current @ 5.0 V
\end{tabular} & \begin{tabular}{l}
\(\mathbf{V}_{\text {Refout }}\) \\
\(\mathrm{V}_{\text {Refin }}\) \\
\(\mathrm{I}_{\text {REFIN }}\)
\end{tabular} & \[
\begin{aligned}
& 4.97 \\
& 3.0 \\
& 4.5
\end{aligned}
\] & \[
\begin{aligned}
& 5.00 \\
& \pm 15 \\
& 5.0 \\
& 5.0
\end{aligned}
\] & \[
\begin{aligned}
& 5.03 \\
& \pm 25 \\
& \\
& 5.5 \\
& 3.0
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{ppm} / \circ \mathrm{C} \\
& \mathrm{~mA} \\
& \mathrm{~V} \\
& \mathrm{~mA}
\end{aligned}
\] \\
\hline \[
\begin{aligned}
& \text { POWER SUPPLY GAIN SENSITIVITY } \\
& \Delta \mathrm{Gain} / \Delta \mathrm{V}_{\mathrm{DD}}, \mathrm{~V}_{\mathrm{DD}}=+10.8 \text { to }+13.2 \mathrm{~V} \mathrm{dc}{ }^{1} \\
& \Delta \mathrm{Gain} / \Delta \mathrm{V}_{\mathrm{ss}}, \mathrm{~V}_{\mathrm{ss}}=-10.8 \text { to }-13.2 \mathrm{~V} \mathrm{dc}^{1}
\end{aligned}
\] & & & \[
\begin{aligned}
& \pm 15 \\
& \pm 15
\end{aligned}
\] & \[
\begin{aligned}
& \pm 25 \\
& \pm 25
\end{aligned}
\] & ppm of FSR/\% ppm of FSR/ \(\%\) \\
\hline \begin{tabular}{l}
POWER SUPPLY REQUIREMENTS \\
Voltage Range Supply Currents
\end{tabular} & \[
\begin{aligned}
& \mathrm{v}_{\mathrm{DD}}, \mathrm{v}_{\mathrm{ss}} \\
& \mathrm{I}_{\mathrm{DD}}, \mathrm{I}_{\mathrm{ss}}
\end{aligned}
\] & \(\pm 10.8\) & \[
\begin{aligned}
& \pm 12 \\
& \pm 25
\end{aligned}
\] & \[
\begin{aligned}
& \pm 13.2 \\
& \pm 30
\end{aligned}
\] & \[
\underset{\mathrm{mA}}{\mathrm{v}}
\] \\
\hline \begin{tabular}{l}
TEMPERATURE RANGE \\
Specification Storage
\end{tabular} & \(\mathrm{T}_{\text {min }}, \mathrm{T}_{\text {max }}\) & \[
\begin{aligned}
& 0 \\
& -65
\end{aligned}
\] & & \[
\begin{aligned}
& +70 \\
& +150
\end{aligned}
\] & \[
\begin{aligned}
& { }^{\circ} \mathrm{C} \\
& { }^{\circ} \mathrm{C}
\end{aligned}
\] \\
\hline
\end{tabular}

\section*{NOTES}
\({ }^{1}\) Gain and bipolar zero errors are measured using internal voltage reference and include its errors.
\({ }^{2}\) Digital crosstalk is defined as the change in any one output's steady state value as a result of any other output being driven from \(V_{\text {outmin }}\) to \(V_{\text {outmax }}\) into a \(2 \mathrm{k} \Omega \| 500 \mathrm{pF}^{\mathrm{F}}\) load by means of vanying the digital input code.
\({ }^{3}\) The internal voltage reference is intended to drive on-chip only; buffer it if using it externally.
\({ }^{4}\) All minimum and maximum specifications are guaranteed, and specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels.
Specifications subject to change without notice.

TIMING CHARACTERISTICS \({ }^{1}\) \(\left(T_{A}=+25^{\circ} \mathrm{C}, \pm 12.0 \mathrm{~V}\right.\) power supplies unless otherwise noted)
\begin{tabular}{l|l|l|l}
\hline Parameter & Symbol & Min & Units \\
\hline Address Setup Time & \(\mathrm{t}_{\mathbf{1}}\) & 30 & ns \\
Address Hold Time & \(\mathrm{t}_{\mathbf{2}}\) & 10 & ns \\
Data Setup Time & \(\mathrm{t}_{\mathbf{3}}\) & 10 & ns \\
Data Hold Time & \(\mathrm{t}_{4}\) & 45 & ns \\
Chip Select to Write Setup Time & \(\mathrm{t}_{5}\) & 0 & ns \\
Write to Chip Select Hold Time & \(\mathrm{t}_{6}\) & 0 & ns \\
Write Pulse Width & \(\mathrm{t}_{7}\) & 50 & ns \\
\hline
\end{tabular}

\section*{NOTES}

\({ }^{1}\) Timing measurement reference level is 1.5 V .
Specifications subject to change without notice.
ABSOLUTE MAXIMUM RATINGS* \({ }^{\star}\left(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right.\) unless otherwise noted)
\begin{tabular}{l|ll|l|l}
\hline & Min & Max & Units & Conditions \\
\hline \(\mathrm{V}_{\text {DD }}\) to DGND & -0.3 & +18 & V & \\
\(\mathrm{~V}_{\text {Ss }}\) to DGND & -18 & +0.3 & V & \\
\(\mathrm{~V}_{\text {DD }}\) to \(\mathrm{V}_{\text {SS }}\) & -0.3 & +26.4 & V & \\
\(\mathrm{~V}_{\text {REFIN }}\) to AGND & -0.3 & \(\mathrm{~V}_{\text {DD }}\) & V & \\
Digital Inputs to DGND & -0.3 & \(\mathrm{~V}_{\mathrm{DD}}\) & V & \\
AGND to DGND & -0.3 & +0.3 & V & \\
Short to AGND on Analog Outputs & & Indefinite & sec & \\
Power Dissipation & & 1.0 & W & \(\mathrm{~T}_{\mathrm{A}} \leq 75^{\circ} \mathrm{C}\) \\
Specification Temperature Range & 0 & +70 & \({ }^{\circ} \mathrm{C}\) & \\
Storage Temperature & -65 & +150 & \({ }^{\circ} \mathrm{C}\) & \\
Lead Temperature & & +300 & \({ }^{\circ} \mathrm{C}\) & Soldering, 10 seconds \\
\hline
\end{tabular}
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TRUTH TABLE
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline \multicolumn{6}{|c|}{Control and Address Lines} & \multirow[b]{2}{*}{Operation} \\
\hline \(\overline{\mathbf{C S}}\) & \(\bar{W} \mathbf{R}\) & A3 & A2 & A1 & A0 & \\
\hline 1 & X & X & X & X & X & No operation \\
\hline X & 1 & X & X & X & X & No operation \\
\hline 0 & 0 & 0 & 0 & Al* & A0* & 8 LSBs \(\rightarrow\) one input latch \\
\hline 0 & 0 & 0 & 1 & A1* & \(\mathrm{A} 0^{\star}\) & \(4 \mathrm{MSBs} \rightarrow\) one input latch \\
\hline 0 & 0 & 1 & 0 & A1* & \(\mathrm{A} 0^{\star}\) & Update one DAC latch \\
\hline 0 & 0 & 1 & 1 & X & X & Update all 4 DAC latches \\
\hline
\end{tabular}

\section*{NOTE}
\(*\) The A1 and A0 inputs specify the relevant channel.
\begin{tabular}{ccc} 
A1 & A0 & Channel \\
0 & 0 & 0 \\
0 & 1 & 1 \\
1 & 0 & 2 \\
1 & 1 & 3
\end{tabular}

\section*{CAUTION}

ESD (electrostatic discharge) sensitive device. The digital control inputs are Zener protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are removed.


PIN DESCRIPTIONS
\begin{tabular}{|c|c|c|c|}
\hline \[
\begin{aligned}
& \text { PLCC } \\
& \text { Pin }
\end{aligned}
\] & \begin{tabular}{l}
Plastic \\
DIP \\
Pin
\end{tabular} & Name & Description \\
\hline 1 & 1 & D7 & Data Input Bit 7 \\
\hline 2 & 2 & D6 & Data Input Bit 6 \\
\hline 3 & 3 & D5 & Data Input Bit 5 \\
\hline 5 & 4 & D4 & Data Input Bit 4 \\
\hline 6 & 5 & D3 & Data Input Bit 3 or 11 (MSB) \\
\hline 7 & 6 & D2 & Data Input Bit 2 or 10 \\
\hline 9 & 7 & D1 & Data Input Bit 1 or 9 \\
\hline 10 & 8 & D0 & Data Input Bit 0 (LSB) or 8 \\
\hline 11 & 9 & CS & Chip Select Input; Active Low \\
\hline 13 & 10 & WR & Write Input; Active Low \\
\hline 14 & 11 & A3 & Address Input Bit 3 (MSB) \\
\hline 15 & 12 & A2 & Address Input Bit 2 \\
\hline 16 & 13 & A1 & Address Input Bit 1 \\
\hline 17 & 14 & A0 & Address Input Bit 0 (LSB) \\
\hline 18 & 15 & DGND & Digital Ground \\
\hline 19 & 16 & AGND & Analog Ground \\
\hline 20 & 17 & \(\mathrm{V}_{\text {Ss }}\) & -12 V Power Supply \\
\hline 21 & 18 & \(\mathrm{V}_{\text {REFOUT }}\) & +5 V Reference Output \\
\hline 22 & 19 & \(\mathrm{V}_{\text {REFIN }}\) & Reference Input \\
\hline 23 & 20 & \(V_{\text {Outo }}\) & Analog Output 0 \\
\hline 24 & 21 & V Out1 & Analog Output 1 \\
\hline 26 & 22 & \(\mathrm{V}_{\text {OUT2 }}\) & Analog Output 2 \\
\hline 27 & 23 & \(\mathrm{V}_{\text {OUT3 }}\) & Analog Output 3 \\
\hline 28 & 24 & \(V_{\text {DD }}\) & +12 V Power Supply \\
\hline 4 & - & NC & No Internal Connection \\
\hline 8 & - & NC & No Internal Connection \\
\hline 12 & - & NC & No Internal Connection \\
\hline 25 & - & NC & No Internal Connection \\
\hline
\end{tabular}

BINARY CODE TABLE
\begin{tabular}{|c|c|c|c|}
\hline \multicolumn{3}{|l|}{Twos Complement Value in DAC Latch} & Analog Output Voltage \\
\hline MSB & & LSB & \\
\hline 0111 & 1111 & 1111 & (2047/2048) * \(\mathrm{V}_{\text {REFIN }}\) \\
\hline 0000 & 0000 & 0001 & \((1 / 2048) \star \mathrm{V}_{\text {REFIN }}\) \\
\hline 0000 & 0000 & 0000 & 0 V \\
\hline 1111 & 1111 & 1111 & - (1/2048)* \(\mathrm{V}_{\text {REFIN }}\) \\
\hline 1000 & 0000 & 0000 & \(-\mathrm{V}_{\text {REFIN }}\) \\
\hline
\end{tabular}

PIN CONFIGURATIONS
24-Pin Plastic DIP


28-Pin PLCC


\section*{ORDERING GUIDE}
\begin{tabular}{l|l|l}
\hline Model & Temperature Range & Package Option \\
\hline AD75004KN & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & \(\mathrm{N}-24 \mathrm{~A}\) \\
AD75004KP & \(0^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\) & \(\mathrm{P}-28 \mathrm{~A}\) \\
\hline
\end{tabular}

\footnotetext{
* \(\mathrm{N}=\) Plastic DIP; \(\mathbf{P}=\) Plastic Leaded Chip Carrier. For outline information see Package Information section.
}

\section*{AD DAC80/AD DAC85/AD DAC87}

\author{
FEATURES \\ Single Chip Construction \\ On-Board Output Amplifier \\ Low Power Dissipation: 300mW \\ Monotonicity Guaranteed over Temperature \\ Guaranteed for Operation with \(\pm 12 \mathrm{~V}\) Supplies \\ Improved Replacement for Standard DAC80, DAC800 HI-5680 \\ High Stability, High Current Output Buried Zener Reference \\ Laser Trimmed to High Accuracy: \(\pm 1 / 2\) LSB max Nonlinearity \\ Low Cost Plastic Packaging
}

FUNCTIONAL BLOCK DIAGRAMS


\section*{PRODUCT HIGHLIGHTS}
1. The AD DAC80 series of D/A converters directly replaces all other devices of this type with significant increases in performance.
2. Single chip construction and low power consumption provides the optimum choice for applications where low cost and high reliability are major considerations.
3. The high speed output amplifier has been designed to settle within \(1 / 2 \mathrm{LSB}\) for a 10 V full scale transition in \(2.0 \mu \mathrm{~s}\), when properly compensated.
4. The precision buried Zener reference can supply up to 2.5 mA for use elsewhere in the application.
5. The low TC binary ladder guarantees that all units are monotonic over the specified temperature range.
6. System performance upgrading is possible without redesign.

\section*{PRODUCT OFFERING}

Analog Devices has developed a number of technologies to support products within the data acquisition market. In serving the market new products are implemented with the technology best suited to the application. The DAC80 series of products was first implemented in hybrid form and now it is available in a single monolithic chip. We will provide both the hybrid and monolithic versions of the family so that in existing designs changes to documentation or product qualification will not have to be done. Specifications and ordering information for both versions are delineated in this data sheet.

\section*{PRODUCT DESCRIPTION}

The AD DAC80 Series is a family of low cost 12-bit digital-to-analog converters with both a high stability voltage reference and output amplifier combined on a single monolithic chip. The AD DAC80 Series is recommended for all low cost 12 -bit D/A converter applications where reliability and cost are of paramount importance.
Advanced circuit design and precision processing techniques result in significant performance advantages over conventional DAC80 devices. Innovative circuit design reduces the total power consumption to 300 mW which not only improves reliability but also improves long term stability.
The AD DAC80 incorporates a fully differential, non-saturating precision current switching cell structure which provides greatly increased immunity to supply voltage variation. This same structure also reduces nonlinearities due to thermal transients as the various bits are switched; nearly all critical components operate at constant power dissipation. High stability, SiCr thin film resistors are trimmed with a fine resolution laser, resulting in lower differential nonlinearity errors. A low noise, high stability, subsurface Zener diode is used to produce a reference voltage with excellent long term stability, high external current capability and temperature drift characteristics which challenge the best discrete Zener references.
The AD DAC80 Series is available in three performance grades and two package types. The AD DAC80 is specified for use over the 0 to \(+70^{\circ} \mathrm{C}\) temperature range and is available in both plastic and ceramic DIP packages. The AD DAC85 and AD DAC87 are available in hermetically sealed ceramic packages and are specified for the \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) and \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) temperature ranges.

\({ }^{7}\) A minimum of \(\pm 12.3 \mathrm{~V}\) is required for a \(\pm 10 \mathrm{~V}\) full scale output and \(\pm 11.4 \mathrm{~V}\) is required for all other voltage ranges.
Specifications subject to change without notice.
Specifications subject to change without notice.
Specifications shown in boldface are tested on all production units at final electri-
\({ }^{6}\) Maximum with no degradation of specification, must be a constant load.
cal Results from those tests are used to calculate outgoing quality levels. All \(\min\) and \(\max\) specifications are guaranteed, although only those shown in


\section*{NOTES}
\({ }^{1}\) Least Significant Bit.
\({ }^{2}\) Adjustable to zero with external trim potentiometer.
\({ }^{3} \mathrm{FSR}\) means "Full Scale Range" and is 20 V for the \(\pm 10 \mathrm{~V}\) range and 10 V for the \(\pm 5 \mathrm{~V}\) range.
\({ }^{4}\) Gain and offset errors adjusted to zero at \(+25^{\circ} \mathrm{C}\).
\({ }^{3} \mathrm{C}_{\mathrm{F}}=0\), see Figure 1a.
\({ }^{6} \mathrm{C}_{\mathrm{F}}=0\), see \(\mathrm{Figimure}^{7}\) with no degradation of specification, must be a constant load.
\({ }^{7}\) Including 5 mA load.
\({ }^{8}+5 \mathrm{~V}\) supply required only for CCD versions.
Specifications subject to change without notice.


\section*{NOTES}
\({ }^{\prime}\) Least Significant Bit.
\({ }^{2}\) Adjustable to zero with external trim potentiometer.
\({ }^{3}\) FSR means "Full Scale Range" and is 20 V for the \(\pm 10 \mathrm{~V}\) range and 10 V for the \(\pm 5 \mathrm{~V}\) range. \({ }^{4}\) Gain and offset errors adjusted to zero at \(+25^{\circ} \mathrm{C}\).
\({ }^{3} \mathrm{C}_{\mathrm{F}}=0\), see Figure la.
\({ }^{{ }^{3}{ }^{6} \text { Maximum with no degradation of specification, must be a constant load. }}\)
Including 5 mA load.
\({ }^{8}+5 \mathrm{~V}\) supply required only for CCD versions.
Specifications subject to change without notice.

\section*{ABSOLUTE MAXIMUM RATINGS}
\(+\mathrm{V}_{\mathrm{s}}\) to Power Ground . . . . . . . . . . . . . . 0 V to +18 V
- V to Power Ground . . . . . . . . . . . . . . \(0 V\) to -18 V

Digital Inputs (Pins 1 to 12 ) to Power Ground . . . -1.0 V to \(+7 \mathrm{~V}\)

Ref In to Reference Ground . . . . . . . . . . . . . . . \(\pm 12 \mathrm{~V}\)
Bipolar Offset to Reference Ground . . . . . . . . . . . \(\pm 12 \mathrm{~V}\)
10V Span R to Reference Ground . . . . . . . . . . . . \(\pm 12 \mathrm{~V}\)
20V Span R to Reference Ground . . . . . . . . . . . . \(\pm 24 \mathrm{~V}\)
Ref Out . . . . . . . Indefinite short to power ground or \(+\mathrm{V}_{\mathrm{S}}\)


Current Model Functional Diagram and Pin Configuration

\section*{ORDERING GUIDE}
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline Model & Input Code & Output Mode & Technology & Temperature Range & Linearity Error & Package Option \({ }^{\star}\) \\
\hline AD DAC80N-CBI-V & Binary & Voltage & Monolithic & 0 to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & N-24A \\
\hline AD DAC80D-CBI-V & Binary & Voltage & Monolithic & 0 to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & D-24 \\
\hline AD DAC85D-CBI-V & Binary & Voltage & Monolithic & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & D-24 \\
\hline AD DAC87D-CBI-V & Binary & Voltage & Monolithic & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 / 2\) LSB & D-24 \\
\hline AD DAC80-CBI-V & Binary & Voltage & Hybrid & 0 to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 / 2\) LSB & DH-24A \\
\hline AD DAC80-CBI-I & Binary & Current & Hybrid & 0 to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 / 2\) LSB & DH-24A \\
\hline AD DAC80-CCD-V & Binary Coded Decimal & Voltage & Hybrid & 0 to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 / 4 \mathrm{LSB}\) & DH-24A \\
\hline AD DAC80-CCD-I & Binary Coded Decimal & Current & Hybrid & 0 to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 / 4 \mathrm{LSB}\) & DH-24A \\
\hline AD DAC80Z-CBI-V** & Binary & Voltage & Hybrid & 0 to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & DH-24A \\
\hline AD DAC80Z-CBI-İ* & Binary & Current & Hybrid & 0 to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & DH-24A \\
\hline AD DAC80Z-CCD-V** & Binary Coded Decimal & Voltage & Hybrid & 0 to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 / 4 \mathrm{LSB}\) & DH-24A \\
\hline AD DAC80Z-CCD-I** & Binary Coded Decimal & Current & Hybrid & 0 to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 / 4 \mathrm{LSB}\) & DH-24A \\
\hline AD DAC85C-CBI-V & Binary & Voltage & Hybrid & 0 to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 / 2\) LSB & DH-24A \\
\hline AD DAC85C-CBI-I & Binary & Current & Hybrid & 0 to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 / 2\) LSB & DH-24A \\
\hline AD DAC85-CBI-V & Binary & Voltage & Hybrid & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & DH-24A \\
\hline AD DAC85-CBI-I & Binary & Current & Hybrid & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & DH-24A \\
\hline AD DAC85LD-CBI-V & Binary & Voltage & Hybrid & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2\) LSB & DH-24A \\
\hline AD DAC85LD-CBI-I & Binary & Current & Hybrid & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 2\) LSB & DH-24A \\
\hline AD DAC85MIL-CBI-V & Binary & Voltage & Hybrid & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & DH-24A \\
\hline AD DAC85MIL-CBI-I & Binary & Current & Hybrid & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 / 2\) LSB & DH-24A \\
\hline AD DAC85C-CCD-V & Binary Coded Decimal & Voltage & Hybrid & 0 to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 / 4 \mathrm{LSB}\) & DH-24A \\
\hline AD DAC85C-CCD-I & Binary Coded Decimal & Current & Hybrid & 0 to \(+70^{\circ} \mathrm{C}\) & \(\pm 1 / 4 \mathrm{LSB}\) & DH-24A \\
\hline AD DAC85-CCD-V & Binary Coded Decimal & Voltage & Hybrid & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 4 \mathrm{LSB}\) & DH-24A \\
\hline AD DAC85-CCD-I & Binary Coded Decimal & Current & Hybrid & \(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & \(\pm 1 / 4 \mathrm{LSB}\) & DH-24A \\
\hline AD DAC87-CBI-V & Binary & Voltage & Hybrid & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & DH-24A \\
\hline AD DAC87-CBI-I & Binary & Current & Hybrid & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & \(\pm 1 / 2 \mathrm{LSB}\) & DH-24A \\
\hline
\end{tabular}

\footnotetext{
*For outline information see Package Information section.
**Z-Suffix devices guarantee performance of 0 to +5 V and \(\pm 5 \mathrm{~V}\) spans with minimum supply voltages of \(\pm 11.4 \mathrm{~V}\).
}

\title{
8-Bit, High Speed, Multiplying D/A Converter (Universal Digital Logic Interface)
}

\section*{\(\square\)}
- Fast Settling Output Current ......................... . . 85ns
- Full-Scale Current Prematched to \(\pm 1\) LSB
- Direct Interface to TTL, CMOS, ECL, HTL, PMOS
- Nonlinearity to . \(\mathbf{0 . 1 \%}\) Maximum Over Temperature Range
- High Output Impedance and Compliance
\(-10 V\) to +18 V
- Complementary Current Outputs
- Wide Range Multiplying Capability ... 1MHz Bandwidth
- Low FS Current Drift
. \(\pm 10 \mathrm{ppm} /{ }^{\circ} \mathrm{C}\)
- Wide Power Supply Range . .............. \(\pm 4.5 \mathrm{~V}\) to \(\pm 18 \mathrm{~V}\)
- Low Power Consumption ................. 33mW @ \(\pm 5 \mathrm{~V}\)
- Low Cost
- Available in Die Form

\section*{GENERAL DESCRIPTION}

The DAC-08 series of 8 -bit monolithic digital-to-analog converters provide very high-speed performance coupled with low cost and outstanding applications flexibility.
Advanced circuit design achieves 85 ns settling times with very low "glitch" energy and at low power consumption. Monotonic multiplying performance is attained over a wide 20 to 1 reference current range. Matching to within 1 LSB between reference and full-scale currents eliminates the need for full-scale trimming in most applications. Direct
interface to all popular logic families with full noise immunity is provided by the high swing, adjustable threshold logic input.
High voltage compliance complementary current outputs are provided, increasing versatility and enabling differential operation to effectively double the peak-to-peak output swing. In many applications, the outputs can be directly converted to voltage without the need for an external op amp.
All DAC-08 series models guarantee full 8-bit monotonicity, and nonlinearities as tight as \(\pm 0.1 \%\) over the entire operating temperature range are available. Device performance is essentially unchanged over the \(\pm 4.5\) to \(\pm 18 \mathrm{~V}\) power supply range, with 33 mW power consumption attainable at \(\pm 5 \mathrm{~V}\) supplies.

The compact size and low power consumption make the DAC-08 attractive for portable and military/aerospace applications; devices processed to MIL-STD-883, Level B are available.
DAC-08 applications include 8-bit, \(1 \mu \mathrm{~S}\) A/D converters, servo motor and pen drivers, waveform generators, audio encoders and attenuators, analog meter drivers, programmable power supplies, CRT display drivers, high-speed modems and other applications where low cost, high speed and complete input/ output versatility are required.

\section*{EQUIVALENT CIRCUIT}


\footnotetext{
This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.
}

ABSOLUTE MAXIMUM RATINGS (Note 1)


Reference Input Differential Voltage
\[
\begin{aligned}
& \text { ( } V_{14} \text { to } V_{15} \text { ) } \\
& \pm 18 \mathrm{~V}
\end{aligned}
\]

Reference Input Current ( \(\mathrm{I}_{14}\) ) ........................................ 5.0 mA
\begin{tabular}{|c|c|c|c|}
\hline PACKAGE TYPE & \(\theta_{\text {IA }}\) (NOTE 2) & \(\theta_{\text {Ic }}\) & UNITS \\
\hline 16-Pin Hermetic DIP (Q) & 100 & 16 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
\hline 16-Pin Plastic DIP (P) & 82 & 39 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
\hline 20-Contact LCC (RC) & 76 & 36 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
\hline 16-Pin SO (S) & 111 & 35 & \({ }^{\circ} \mathrm{C} / \mathrm{N}\) \\
\hline
\end{tabular}

\section*{NOTES:}
1. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
2. \(\boldsymbol{\Theta}_{j A}\) is specified for worst case mounting conditions, i.e., \(\boldsymbol{\Theta}_{j A}\) is specified for device in socket for CerDIP, P-DIP, and LCC packages; \(\boldsymbol{\theta}_{j A}\) is specified for device soldered to printed circuit board for SO package.

ELECTRICAL CHARACTERISTICS at \(\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{I}_{\text {REF }}=2.0 \mathrm{~mA},-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}\) for DAC-08/08A, \(0^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+70^{\circ} \mathrm{C}\) for DAC-08C, E \& H, unless otherwise noted. Output characteristics refer to both IOUT and IOUT.
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{PARAMETER} & \multirow[b]{2}{*}{SYMBOL} & \multirow[b]{2}{*}{CONDITIONS} & \multicolumn{3}{|l|}{DAC-08A/H} & \multicolumn{3}{|c|}{DAC-08E} & \multicolumn{3}{|c|}{DAC-08C} & \multirow[b]{2}{*}{UNITS} \\
\hline & & & MIN & TYP & MAX & MIN & TYP & MAX & MIN & TYP & MAX & \\
\hline Resolution & & & 8 & - & - & 8 & - & - & 8 & - & - & Bits \\
\hline Monotonicity & & & 8 & - & - & 8 & - & - & 8 & - & - & Bits \\
\hline Nonlinearity & NL & & - & - & \(\pm 0.1\) & - & - & \(\pm 0.19\) & - & - & \(\pm 0.39\) & \%FS \\
\hline Settling Time & \({ }^{\text {t }}\) S & To \(\pm 1 / 2\) LSB, all bits switched ON or OFF, \(\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\), (Note) & - & 85 & 135 & - & 85 & 150 & - & 85 & 150 & ns \\
\hline Propagation Delay Each bit All bits switched & \[
\begin{aligned}
& \mathrm{t}_{\mathrm{PLH}} \\
& \mathrm{t}_{\mathrm{PHL}}
\end{aligned}
\] & \begin{tabular}{l}
\[
T_{A}=25^{\circ} \mathrm{C}
\] \\
(Note)
\end{tabular} & - & \[
\begin{aligned}
& 35 \\
& 35
\end{aligned}
\] & 60
60 & - & 35
35 & 60
60 & - & 35
35 & 60
60 & ns \\
\hline Full-Scale Tempco (Note) & \(\mathrm{TCl}_{\text {FS }}\) & DAC-08E & - & \[
\begin{array}{r} 
\pm 10 \\
-
\end{array}
\] & \(\pm 50\) & - & \(\pm 10\)
- & \[
\begin{aligned}
& \pm 80 \\
& \pm 50
\end{aligned}
\] & - & \(\pm 10\)
- & \(\pm 80\)
- & \(\mathrm{ppm} /{ }^{\circ} \mathrm{C}\) \\
\hline Output Voltage Compliance , True Compliance & \(v_{\text {OC }}\) & Full-Scale current change <1/2 LSB, R OUT \(>20 \mathrm{M} \Omega\) typical & -10 & - & +18 & -10 & - & +18 & -10 & - & +18 & V \\
\hline Full Range Current & \(\mathrm{I}_{\text {FR4 }}\) & \[
\begin{aligned}
& V_{R E F}=10.000 \mathrm{~V} \\
& R_{14}, R_{15}=5.000 \mathrm{k} \Omega \\
& T_{A}=+25^{\circ} \mathrm{C} \\
& \hline
\end{aligned}
\] & 1.984 & 1.992 & 2.000 & 1.94 & 1.99 & 2.04 & 1.94 & 1.99 & 2.04 & mA \\
\hline Full Range Symmetry & \(I_{\text {FRS }}\) & \(\mathrm{I}_{\text {FR } 4}-\mathrm{I}_{\text {FR2 }}\) & - & \(\pm 0.5\) & \(\pm 4\) & - & \(\pm 1\) & \(\pm 8\) & - & \(\pm 2\) & \(\pm 16\) & \(\mu \mathrm{A}\) \\
\hline Zero-Scale Current & \(\mathrm{I}_{\mathrm{zS}}\) & & - & 0.1 & 1 & - & 0.2 & 2 & - & 0.2 & 4 & \(\mu \mathrm{A}\) \\
\hline Output Current Range & \[
\begin{aligned}
& I O R_{1} \\
& I O R_{2}
\end{aligned}
\] & \[
\begin{aligned}
& R_{14}, R_{15}=5.000 \mathrm{k} \Omega \\
& V_{\text {REF }}=+15.0 \mathrm{~V}, \mathrm{~V}-=-10 \mathrm{~V} \\
& V_{\text {REF }}=+25.0 \mathrm{~V}, \mathrm{~V}-=-12 \mathrm{~V}
\end{aligned}
\] & \begin{tabular}{l}
2.1 \\
4.2
\end{tabular} &  & -
- & 2.1
4.2 & - & -
- & 2.1
4.2 & -
- & -
- & mA \\
\hline Output Current Noise & & \(\mathrm{I}_{\text {REF }}=2 \mathrm{~mA}\) & - & 25 & - & - & 25 & - & - & 25 & - & nA \\
\hline ```
Logic Input Levels
    Logic "0"
    Logic Input "1"
``` & \[
\begin{aligned}
& v_{\mathrm{IL}} \\
& \mathrm{v}_{\mathrm{IL}}
\end{aligned}
\] & \(\mathrm{V}_{\mathrm{LC}}=0 \mathrm{~V}\) & \[
-
\] & - & 0.8 & - & - & 0.8 & - & - & 0.8 & V \\
\hline \begin{tabular}{l}
Logic Input Current \\
Logic "0" \\
Logic Input "1"
\end{tabular} & \[
\begin{aligned}
& I_{I L} \\
& I_{\mathrm{IH}}
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{V}_{\mathrm{LC}}=0 \mathrm{~V} \\
& \mathrm{~V}_{\mathrm{IN}}=-10 \mathrm{~V} \text { to }+0.8 \mathrm{~V} \\
& \mathrm{~V}_{\mathrm{IN}}=2.0 \mathrm{~V} \text { to } 18 \mathrm{~V}
\end{aligned}
\] & - & \[
\begin{array}{r}
-2 \\
0.002
\end{array}
\] & & - & -2
0.002 & \[
\begin{array}{r}
-10 \\
10
\end{array}
\] & - & -2
0.002 & \[
\begin{array}{r}
-10 \\
10
\end{array}
\] & \(\mu \mathrm{A}\) \\
\hline Logic Input Swing & \(\mathrm{V}_{\text {IS }}\) & \(\mathrm{V}-=-15 \mathrm{~V}\) & -10 & - & +18 & -10 & - & +18 & -10 & - & +18 & V \\
\hline Logic Threshold Range & \(\mathrm{V}_{\text {THR }}\) & \(\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}\), (Note) & -10 & - & +13.5 & -10 & - & +13.5 & -10 & - & +13.5 & V \\
\hline Reference Bias Current & \(\mathrm{I}_{15}\) & & - & -1 & -3 & - & -1 & -3 & - & -1 & -3 & \(\mu \mathrm{A}\) \\
\hline Reference Input Slew Rate & \(\mathrm{dl} / \mathrm{dt}\) & \begin{tabular}{l}
\(R_{E Q}=200 \Omega\) See fast pulsed \\
\(R_{L}=100 \Omega\) ref. info. \\
\(\mathrm{C}_{\mathrm{C}}=0 \mathrm{pF} \quad\) following. (Note)
\end{tabular} & 4 & 8 & - & 4 & 8 & - & 4 & 8 & - & \(\mathrm{mA} / \mu \mathrm{S}\) \\
\hline Power Supply Sensitivity & \[
\begin{aligned}
& \text { PSSI }_{\text {FS }+} \\
& \text { PSSI }_{\text {FS- }}
\end{aligned}
\] & \[
\begin{aligned}
& \mathrm{V}+=4.5 \mathrm{~V} \text { to } 18 \mathrm{~V} \\
& \mathrm{~V}-=-4.5 \mathrm{~V} \text { to }-18 \mathrm{~V} \\
& \mathrm{I}_{\text {REF }}=1.0 \mathrm{~mA}
\end{aligned}
\] & & \[
\begin{aligned}
& 0.0003 \\
& \pm 0.002
\end{aligned}
\] & \[
\begin{aligned}
& \pm 0.01 \\
& \pm 0.01
\end{aligned}
\] & & \[
\begin{aligned}
& 0.0003 \\
& \pm 0.002
\end{aligned}
\] & \[
\begin{aligned}
& \pm 0.01 \\
& \pm 0.01
\end{aligned}
\] & & \[
\begin{aligned}
& =0.0003 \\
& \pm 0.002
\end{aligned}
\] & \[
\begin{aligned}
& \pm 0.01 \\
& \pm 0.01
\end{aligned}
\] & \[
\begin{aligned}
& ل_{0} \% \Delta V+ \\
& ل_{0} / \% \Delta V-
\end{aligned}
\] \\
\hline
\end{tabular}

NOTE: Guaranteed by design.

ELECTRICAL CHARACTERISTICS at \(\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{I}_{\mathrm{REF}}=2.0 \mathrm{~mA},-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}\) for DAC-08/08A, \(0^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+70^{\circ} \mathrm{C}\) for DAC-08C, E \& H, unless otherwise noted. Output characteristics refer to both I OUT and \(\overline{T_{\text {OUT }}}\). (Continued)
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{PARAMETER} & \multirow[b]{2}{*}{SYMBOL} & & \multicolumn{3}{|l|}{DAC-08A/H} & \multicolumn{3}{|c|}{DAC-08E} & \multicolumn{3}{|c|}{DAC-08C} & \multirow[b]{2}{*}{UNITS} \\
\hline & & CONDITIONS & MIN & TYP & MAX & MIN & TYP & MAX & MIN & TYP & MAX & \\
\hline \multirow{6}{*}{Power Supply Current} & \(1+\) & \(V_{S}= \pm 5 \mathrm{~V}, \mathrm{I}_{\text {REF }}=1.0 \mathrm{~mA}\) & - & 2.3 & 3.8 & - & 2.3 & 3.8 & - & 2.3 & 3.8 & \\
\hline & \(1-\) & & - & -4.3 & -5.8 & - & -4.3 & -5.8 & - & -4.3 & -5.8 & \\
\hline & \(1+\) & \(\mathrm{V}_{\mathrm{S}}=+5 \mathrm{~V},-15 \mathrm{~V}, \mathrm{I}_{\text {REF }}=2.0 \mathrm{~mA}\) & - & 2.4 & 3.8 & - & 2.4 & 3.8 & - & 2.4 & 3.8 & mA \\
\hline & \(1-\) & & - & -6.4 & \(-7.8\) & - & -6.4 & -7.8 & - & -6.4 & -7.8 & mA \\
\hline & \(1+\) & \(V_{S}= \pm 15 \mathrm{~V}, \mathrm{I}_{\mathrm{REF}}=2.0 \mathrm{~mA}\) & - & 2.5 & 3.8 & - & 2.5 & 3.8 & - & 2.5 & 3.8 & \\
\hline & \(1-\) & & - & -6.5 & -7.8 & - & -6.5 & -7.8 & - & -6.5 & -7.8 & \\
\hline \multirow{3}{*}{Power Dissipation} & & \(\pm 5 \mathrm{~V}, \mathrm{I}_{\text {REF }}=1.0 \mathrm{~mA}\) & - & 33 & 48 & - & 33 & 48 & - & 33 & 48 & \\
\hline & \(P_{\text {d }}\) & \(+5 \mathrm{~V},-15 \mathrm{~V}, \mathrm{I}_{\text {REF }}=2.0 \mathrm{~mA}\) & - & 108 & 136 & - & 103 & 136 & - & 108 & 136 & mW \\
\hline & & \(\pm 15 \mathrm{~V}, \mathrm{I}_{\mathrm{REF}}=2.0 \mathrm{~mA}\) & - & 135 & 174 & - & 135 & 174 & - & 135 & 174 & \\
\hline
\end{tabular}

NOTE: Guaranteed by design.

\section*{ORDERING INFORMATION \(\dagger\)}
\begin{tabular}{|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{NL} & \multicolumn{3}{|r|}{16-PIN DUAL-IN-LINE PACKAGE} & \multirow[t]{2}{*}{OPERATING TEMPERATURE RANGE.} \\
\hline & HERMETIC & PLASTIC & LCC & \\
\hline \multirow[b]{2}{*}{0.1\%} & DAC08AQ* & - & - & MIL \\
\hline & DAC08HQ & DAC08HP & - & COM \\
\hline \multirow[t]{2}{*}{0.19\%} & DAC08Q* & - & DAC08RC/883 & MIL \\
\hline & DAC08EQ & DAC08EP & . - & COM \\
\hline \multirow[b]{2}{*}{0.39\%} & DAC08CQ & DAC08CP & - & COM \\
\hline & - & DAC08CS \(\dagger \dagger\) & - & COM \\
\hline
\end{tabular}

\footnotetext{
* For devices processed in total compliance to MIL-STD-883, add /883 after part number. Consult factory for 883 data sheet.
\(\dagger\) Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.
t \(\dagger\) For availability and burn-in information on SO and PLCC packages, contact your local sales office.
}

\section*{PIN CONNECTIONS}


FEATURES
\(\pm 1\) LSB Differential Linearity (max)
Guaranteed Monotonic Over Temperature Range
\(\pm 2\) LSB Integral Linearity (max)
500 ns Settling Time
5 mA Full-Scale Output
TTL/CMOS Compatible
Low Power: 190 mW (typ)
Available in Die Form
APPLICATIONS
Communications
ATE
Data Acquisition Systems High Resolution Displays

\section*{GENERAL DESCRIPTION}

The DAC16 is a 16 -bit high speed current-output digital-toanalog converter with a settling time of 500 ns . A unique combination of low distortion, high signal-to-noise ratio, and high speed make the DAC16 ideally suited to performing waveform synthesis and modulation in communications, instrumentation, and ATE systems. Input reference current is buffered, with fullscale output current of 5 mA . The 16-bit parallel digital input bus is TTL/CMOS compatible. Operating from +5 V and -15 V supplies, the DAC16 consumes 190 mW (typ) and is available in a 24 -pin epoxy DIP, epoxy surface-mount small outline (SOL), ceramic side brazed DIP, 28-pin leadless ceramic chip carrier (LCC) packages, and in die form.

FUNCTIONAL BLOCK DIAGRAM


Figure 1. DAC16 Settling Time Accuracy vs. Percent of Full Scale

\section*{ORDERING GUIDE}
\begin{tabular}{l|l|l|l|l}
\hline Model & Grade DNL (max) & Temperature Range & Package Description & Package Option \({ }^{\mathbf{1}}\) \\
\hline DAC16EP & \(\pm 1\) & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 24 -Pin PDIP & N-24 \\
DAC16ES & \(\pm 1\) & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 24 -Pin SOL & R-24 \\
DAC16FP & \(\pm 2\) & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 24 -Pin PDIP & N-24 \\
DAC16FS & \(\pm 2\) & \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\) & 24-Pin SOL & R-24 \\
DAC16BVB \(^{2}\) & \(\pm 2\) & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 24 -Pin Ceramic DIP & D-24A \\
DAC16BTC \(^{2}\) & \(\pm 2\) & \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) & 28 -Pin LCC & E-28A \\
DAC16GBC & \(\pm 1\) & \(+25^{\circ} \mathrm{C}\) & Die & \\
\hline
\end{tabular}

\footnotetext{
NOTES
\({ }^{1}\) For package outline information see Package Information section.
\({ }^{2}\) Consult factory for availability.
}

\section*{DAC16-SPECIFICATIONS}

ELECTRICAL CHARACTERISTICS \(\begin{aligned} & \left(@ V_{\mathrm{CC}}=+5.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-15.0 \mathrm{~V}, \mathrm{I}_{\mathrm{REF}}=0.5 \mathrm{~mA}, \mathrm{C}_{\text {comp }}=47 \mu \mathrm{~F},\right. \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \text { unless otherwise noted. See Note } 1 \text { for supply variations.) }\end{aligned}\)
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline Parameter & & Conditions & Min & Typ & Max & Units \\
\hline Integral Linearity "E" & INL & \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) & -2 & \(\pm 1.2\) & +2 & LSB \\
\hline Integral Linearity "E" & INL & & -4 & \(\pm 1.6\) & +4 & LSB \\
\hline Differential Linearity "E" & DNL & \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) & -1 & \(\pm 0.5\) & +1 & LSB \\
\hline Differential Linearity " \(E\) " & DNL & & -1 & \(\pm 0.7\) & +1.5 & LSB \\
\hline Integral Linearity "F" & INL & \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) & -4 & \(\pm 1.4\) & +4 & LSB \\
\hline Integral Linearity "F" & INL & & -6 & \(\pm 2\) & +6 & LSB \\
\hline Differential Linearity "F" & DNL & \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) & -1 & \(\pm 0.5\) & +1.5 & LSB \\
\hline Differential Linearity "F" & DNL & & -1.5 & \(\pm 0.6\) & +2 & LSB \\
\hline Zero Scale Error & ZSE & & & & 1 & LSB \\
\hline Zero Scale Drift & \(\mathrm{TC}_{\text {zSE }}\) & . & & 0.025 & & ppm/ \({ }^{\circ} \mathrm{C}\) \\
\hline Gain Error & GE & & & & \(\pm 0.225\) & \% FS \\
\hline Gain Drift & \(\mathrm{TC}_{\mathrm{GE}}\) & & & 5 & & ppm/ \({ }^{\circ} \mathrm{C}\) \\
\hline \begin{tabular}{l}
REFERENCE \({ }^{2}\) \\
Reference Input Current
\end{tabular} & \(\mathrm{I}_{\text {REF }}\) & Note 2 & 350 & & 625 & \(\mu \mathrm{A}\) \\
\hline OUTPUT CHARACTERISTICS Output Current & \(\mathrm{I}_{\text {OUT }}\) & Note 2 & 2.8 & & 5.0 & mA \\
\hline Output Capacitance & \(\mathrm{C}_{\text {Out }}\) & & & 10 & & pF \\
\hline Settling Time & \(\mathrm{t}_{\text {s }}\) & 0.003\% of Full Scale & & 500 & & ns \\
\hline LOGIC CHARACTERISTICS & & & & & & \\
\hline Logic Input High Voltage & \(\mathrm{V}_{\text {INH }}\) & \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) & 2.4 & & & V \\
\hline Logic Input Low Voltage & \(\mathrm{V}_{\text {INL }}\) & \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) & & & 0.8 & V \\
\hline Logic Input Current & \(\mathrm{I}_{\text {INH }}\) & \(\mathrm{V}_{\text {IN }}=5.0 \mathrm{~V}, \mathrm{DB} 0-\mathrm{DB10}\) & & & 7.5 & \(\mu \mathrm{A}\) \\
\hline Logic Input Current & \(\mathrm{I}_{\text {INH }}\) & \(\mathrm{V}_{\mathrm{IN}}=5.0 \mathrm{~V}, \mathrm{DB} 11-\mathrm{DB} 15\) & & & 100 & \(\mu \mathrm{A}\) \\
\hline Logic Input Current & \(\mathrm{I}_{\text {INL }}\) & \(\mathrm{V}_{\text {IN }}=0 \mathrm{~V}, \mathrm{DB} 0-\mathrm{DB} 15\) & & & 1 & \(\mu \mathrm{A}\) \\
\hline Input Capacitance & \(\mathrm{C}_{\text {IN }}\) & & & 8 & & pF \\
\hline SUPPLY CHARACTERISTICS & & & & & & \\
\hline Power Supply Sensitivity & PSS & \(\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}\) to \(5.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-13 \mathrm{~V}\) to -17 V & & & 20 & ppm/V \\
\hline Positive Supply Current & \(\mathrm{I}_{\text {cc }}\) & All Bits HIGH & & 15 & 22 & mA \\
\hline Positive Supply Current & \(\mathrm{I}_{\mathrm{CC}}\) & All Bits LOW & & 6 & 7.5 & mA \\
\hline Negative Supply Current & \(\mathrm{I}_{\mathrm{EE}}\) & & & 7.5 & 10 & mA \\
\hline Power Dissipation & \(\mathrm{P}_{\text {DISS }}\) & & & 188 & 260 & mW \\
\hline
\end{tabular}

NOTES
\({ }^{1}\) All supplies can be varied \(\pm 5 \%\) and operation is guaranteed. Device is tested with nominal supplies.
\({ }^{2}\) Operation is guaranteed over this reference range, but linearity is neither tested nor guaranteed (see Figures 7 and 8 ).
Specifications subject to change without notice.
WAFER TEST LIMITS ( \(@ \mathrm{~V}_{\mathrm{Cc}}=+5.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-15.0 \mathrm{~V}, \mathrm{I}_{\mathrm{REF}}=0.5 \mathrm{~mA}, \mathrm{C}_{\text {COMP }}=47 \mu \mathrm{~F}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) unless otherwise noted. )
\begin{tabular}{|c|c|c|c|c|}
\hline Parameter & Symbol & Conditions & \begin{tabular}{l}
DAC16G \\
Limit
\end{tabular} & Units \\
\hline Integral Nonlinearity & INL & & \(\pm 3\) & LSB max \\
\hline Differential Nonlinearity & DNL & & \(\pm 1\) & LSB max \\
\hline Zero Scale Error & ZSE & & \(\pm 1\) & LSB max \\
\hline Gain Error & GE & & \(\pm 0.12\) & \% FS max \\
\hline Logic Input High Voltage & \(\mathrm{V}_{\text {INH }}\) & & 2.4 & \(V\) min \\
\hline Logic Input Low Voltage & \(\mathrm{V}_{\text {INL }}\) & & 0.8 & \(V\) max \\
\hline Logic Input Current & \(\mathrm{I}_{\mathrm{IN}}\) & & 75 & \(\mu \mathrm{A}\) max \\
\hline Positive Supply Current & \(\mathrm{I}_{\mathrm{CC}}\) & & 20 & \(m_{\text {A max }}\) \\
\hline Negative Supply Current & \(\mathrm{I}_{\mathrm{EE}}\) & & 10 & \(m A \max\) \\
\hline Power Dissipation & \(\mathrm{P}_{\text {DISS }}\) & & 250 & mW max \\
\hline
\end{tabular}

\section*{NOTE}

Electrical tests are performed at wafer probe to the limits shown. Due to variations in assembly methods and normal yield loss, yield after packaging is not guaranteed for standard product dice, Consult factory to negotiate specifications based on dice lot qualification through sample lot assembly and testing.

\section*{DICE CHARACTERISTICS}


Die Size \(0.129 \times 0.153\) inch, 19,737 sq. mils ( \(3.277 \times 3.886 \mathrm{~mm}, 12.73 \mathrm{sq} . \mathrm{mm}\) ) The DAC16 Contains 330 Transistors.

\section*{ABSOLUTE MAXIMUM RATINGS}
( \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\) unless otherwise noted)
\(\mathrm{V}_{\mathrm{CC}}\) to \(\mathrm{V}_{\mathrm{EE}}\). . . . . . . . . . . . . . . . . . . . . . \(-0.3 \mathrm{~V},+25.0 \mathrm{~V}\)
\(\mathrm{V}_{\mathrm{Cc}}\) to DGND . . . . . . . . . . . . . . . . . . . . . \(-0.3 \mathrm{~V},+7.0 \mathrm{~V}\)
\(\mathrm{V}_{\text {EE }}\) to AGND . . . . . . . . . . . . . . . . . . . . \(+0.3 \mathrm{~V},-18.0 \mathrm{~V}\)
DGND to AGND . . . . . . . . . . . . . . . . . . . \(-0.3 \mathrm{~V},+0.3 \mathrm{~V}\)
REF GND to AGND . . . . . . . . . . . . . . . \(-0.3 \mathrm{~V},+1.0 \mathrm{~V}\)
I REF . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 1 mA
Analog Output Current . . . . . . . . . . . . . . . . . . . . . 8 mA
Digital Input Voltage to DGND . . . . . . . . . . . . . . . . \(\leq\) V \(_{\text {Cc }}\)
Operating Temperature Range
EP, FP, ES, FS . . . . . . . . . . . . . . . . . \(-40^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
BTC, BVB . . . . . . . . . . . . . . . . . . . . . \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
Dice Junction Temperature . . . . . . . . . . . . . . . . . . \(+150^{\circ} \mathrm{C}\)
Storage Temperature . . . . . . . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
Power Dissipation . . . . . . . . . . . . . . . . . . . . . . . 1000 mW
Lead Temperature (Soldering, 60 sec ) . . . . . . . . . . \(+300^{\circ} \mathrm{C}\)
\begin{tabular}{l|l|l|l}
\hline Package Type & \(\boldsymbol{\theta}_{\mathbf{J A}}{ }^{\mathbf{1}}\) & \(\boldsymbol{\theta}_{\mathbf{J C}}\) & Units \\
\hline 24-Pin Plastic DIP (P) & \(\mathbf{6 2}\) & 32 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
24-Lead Plastic SOL (S) & 70 & 22 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
24-Lead Size Brazed DIP (VB) & 50 & 26 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
28-Lead Hermetic LCC (TC) & 78 & 30 & \({ }^{\circ} \mathrm{C} / \mathrm{W}\) \\
\hline
\end{tabular}

NOTE
\({ }^{1} \theta_{\mathrm{JA}}\) is specified for worst case mounting conditions, i.e., \(\theta_{\mathrm{JA}}\) is specified for device in socket.

\section*{CAUTION}
1. Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation at or above this specification is not implied. Exposure to the above maximum rating conditions for extended periods may affect device reliability.
2. Digital inputs and outputs are protected; however, permanent damage may occur on unprotected units from high energy electrostatic fields. Keep units in conductive foam or packaging at all times until ready to use. Use proper antistatic handling procedures.
3. Remove power before inserting or removing units from their sockets.

\section*{PACKAGE PINOUTS}



PIN DESCRIPTION
\begin{tabular}{l|l|l|l}
\hline \begin{tabular}{l} 
Pin \\
(P, S, VB)
\end{tabular} & (TC) & Name & Description \\
\hline 1 & 1 & I \(_{\text {REF }}\) & Reference Current Input \\
2 & 2 & DGND & Digital Ground \\
3 & 3 & V \(_{\text {CC }}\) & \begin{tabular}{l} 
+5 V Digital Supply \\
\(4-19\)
\end{tabular} \\
& \(5-23\) & DB15-DB0 & 16-Bit Digital Input Bus. \\
& & & DB15 Is the MSB. \\
20 & 24 & V \(_{\text {EE }}\) & -15 V Analog Supply \\
21 & 25 & REF GND & Reference Current Return \\
22 & 26 & AGND & Analog Ground/Output \\
& & & Reference \\
23 & 27 & \(\mathbf{I}_{\text {OUT }}\) & Current Output \\
24 & 28 & C \(_{\text {COMP }}\) & Current Ladder Compensation \\
& 4,11, & NC & No Connects \\
& 19,22 & & \\
\hline
\end{tabular}


Figure 2. Burn-In Diagram

\section*{OPERATION}

\section*{Novel DAC Architecture}

The DAC16 was designed with a compound DAC architecture to achieve high accuracy, excellent linearity, and low transition errors. As shown in Figure 3, the DAC's five most-significant bits utilize 31 identical segmented current sources to obtain optimal high speed settling at major code transitions. The lower nine bits utilize an inverted R-2R ladder network which is lasertrimmed to ensure excellent differential nonlinearity. The middle two bits (DB9 and DB10) are binary-weighted and scaled from the MSB segments. Note that the flow of output current is into the DAC16 - there is no signal inversion. As shown, the switches for each current source are essentially diodes. It is for this reason that the output voltage compliance of the DAC16 is limited to a few millivolts. The DAC16 was designed to operate with an operational amplifier configured as an I-V converter; therefore, the DAC16's output must be connected to the sum node of an operational amplifier for proper operation. Exceeding the output voltage compliance of the DAC16 will introduce linearity errors. The reference current buffer assures full accuracy
and fast settling by controlling the MSB reference node. The 16-bit parallel digital input is TTL/CMOS compatible and unbuffered, minimizing the deleterious effects of digital feedthrough while allowing the used to tailor the digital interface to the speed requirements and bus configuration of the application.

\section*{Equivalent Circuit Analysis}

An equivalent circuit for static operation of the DAC16 is illustrated in Figure 4. \(\mathrm{I}_{\text {REF }}\) is the current applied to the DAC16 and is set externally to the device by \(\mathrm{V}_{\text {REF }}\) and \(\mathrm{R}_{\text {REF }}\). The output capacitance of the \(\mathrm{DAC16}\) is approximately 10 pF and is code independent. Its output resistance \(R_{O}\) is code dependent and is given by:
\[
\frac{1}{R_{O}}=\frac{1}{8 k \Omega}+\frac{D B 9}{288 k \Omega}+\frac{D B 10}{144 k \Omega}+\frac{X}{72 k \Omega}
\]
where
DB9 \(=\) State of Data Bit \(9=0\) or 1 ;
DB10 \(=\) State of Data Bit \(10=0\) or 1 ; and
\(\mathrm{X}=\) Decimal representation of the \(5 \mathrm{MSBs}(\mathrm{DB} 11-\mathrm{DB} 15)=0\) to 31 .


Figure 4. Equivalent Circuit for the DAC16
Table I provides the relationship between the input digital code and the output resistance of the DAC16.

Table I. DAC16 Output Resistance vs. Digital Code
\begin{tabular}{l|l|l}
\hline Hex Digital Code & Scale & Output Resistance \\
\hline FFFF & Zero & \(8 \mathrm{k} \Omega\) \\
BFFF & \(1 / 4\) & \(4.2 \mathrm{k} \Omega\) \\
7 FFF & \(1 / 2\) & \(2.9 \mathrm{k} \Omega\) \\
3 FFF & \(3 / 4\) & \(2.2 \mathrm{k} \Omega\) \\
0 & Full -1 LSB & \(1.8 \mathrm{k} \Omega\) \\
\hline
\end{tabular}


Figure 3. DAC16 Architecture

\section*{Digital Input Considerations}

The threshold of the DAC16's digital input circuitry is set at 1.4 V , independent of supply voltage. Hence, the digital inputs can interface with any type of 5 V logic. Illustrated in Figure 5 is the equivalent circuit of the digital inputs. Note that the individual input capacitance is approximately 7 pF .


Figure 5. Equivalent Circuit of a DAC16 Digital Input

This input capacitance can be used in conjunction with an external R-C circuit for digital signal deskewing, if required. In applications where some of the DAC16's digital inputs are not used, the recommended procedure to turn off one or more inputs is to connect each input line to +5 V as shown in Figure 6 .

Figure 6. Handling Unused DAC16 Digital Inputs



Figure 7. Integral Nonlinearity vs. \(I_{\text {REF }}\)


Figure 10. Gain Error vs. Temperature


Figure 8. Differential Nonlinearity vs. I \(I_{\text {REF }}\)


Figure 11. Integral Nonlinearity vs. Temperature


Figure 9. Zero Scale Output vs. Temperature


Figure 12. Differential Nonlinearity vs. Temperature

\section*{DAC16 - Typical Performance Characteristics}


Figure 13. Supply Current vs. Temperature


Figure 16. Differential Nonlinearity vs. Time Accelerated by Burn-In


Figure 14. \(V_{c c}\) Supply Current vs. Logic Input Voltage, All Data Bits


Figure 17. Integral Nonlinearity vs. Time Accelerated by Burn-In


Figure 15. Digital Input Current vs. Temperature


Figure 18. Gain Error vs. Time Accelerated by Burn-In

\section*{APPLICATIONS}

\section*{Power Supplies, Bypassing, and Grounding}

All precision converter products require careful application of good grounding practices to maintain full-rated performance. As is always the case with analog circuits operating in digital environments, digital noise is prevalent; therefore, special care must be taken to ensure that the DAC16's inherent precision is maintained. This means that particularly good engineering judgment should be exercised when addressing the power supply, grounding, and bypassing issues using the DAC16.
The DAC16 was designed to operate from +5 V and -15 V supplies. The +5 V supply primarily powers the digital portion of the DAC16 and can consume 20 mA , maximum. Although very little +5 V supply current is used by the reference amplifier, large amounts of digital noise present on the +5 V supply can introduce analog errors. It is therefore very important that the +5 V supply be well filtered and regulated. The -15 V supply provides most of the current for the reference amplifier and all of the current for the internal DAC. Although the maximum current in this supply is 10 mA , it must provide a low impedance path for the DAC switch currents. Therefore, it too must be well filtered and regulated.
The DAC16 includes two ground connections in order to minimize system accuracy degradation arising from grounding errors. The two ground pins are designated DGND (Pin 2) and AGND
(Pin 22). The DGND pin is the return for the digital circuit sections of the DAC and serves as their input threshold reference point. Thus, DGND should be connected to the same ground as the circuitry that drives the digital inputs.
Pin 22, AGND, serves as the reference point for the 9 -bit lowerorder DAC as well as the common for the reference amplifier, REFGND (Pin 21). This pin should also serve as the reference point for all analog circuitry associated with the DAC16. Therefore, to minimize any errors, it is recommended that AGND connection on the DAC16 be connected to a high quality analog ground. If the system contains any analog signal path carrying a significant amount of current, then that path should have its own return connection to Pin 22.
It is often advisable to maintain separate analog and digital grounds throughout a complete system, tying them common to one place only. If the common tie point is remote and an accidental disconnection of that one common tie point were to occur due to card removal with power on, a large differential voltage between the two commons could develop. To protect devices that interface to both digital and analog parts of the system, such as the DAC16, it is recommended that common ground tie points be provided at each such device. If only one system ground can be connected directly to the DAC16, it is recommended that the analog common be used. If the system's AGND has suitable low impedance, then the digital signal currents flowing in it should
not seriously affect the ground noise. The amount of digital noise introduced by connecting the two grounds together at the device will not adversely affect system performance due to loss of digital noise immunity.
Generous bypassing of the DAC's supplies goes a long way in reducing supply-line induced errors. Even with well-filtered, well-regulated supplies, local bypassing consisting of \(10 \mu \mathrm{~F}\) tantalum electrolytic shunted by a \(0.1 \mu \mathrm{~F}\) ceramic is recommended. The decoupling capacitors should be connected between the DAC's supply pins (Pin 3 for +5 V , Pin 20 for -15 V ) and the analog ground (Pin 22). Figure 19 shows how the DGND, AGND, and bypass connections should be made to the DACl6.


Figure 19. Recommended Grounding and Bypassing Scheme for the DAC16

\section*{Using the Right Capacitors}

Probably the most important external components associated with high speed design are the capacitors used to bypass the power supplies and to provide compensation. Both selection and placement of these capacitors can be critical and, to a large extent, dependent upon the specifics of the system configuration. The dominant consideration in selection of bypass and compensation capacitors for the DAC16 is minimization of series resistance and inductance. Many capacitors begin to look inductive at 20 MHz and above-the very frequencies where rejection of interference is needed. Ceramic and film-type capacitors generally feature lower series inductance than tantalum or electrolytic types. A few general rules are of universal use when approaching the issue of compensation or bypassing.
Bypass capacitors should be installed on the printed circuit board with the shortest possible leads consistent with reliable construction. This helps to minimize series inductance in the leads. Chip capacitors are optimal in this respect. Where illustrated in the applications section, large tantalum electrolytic capacitors are shunted by low self-inductance ceramic capacitors. This technique reduces the self-resonance of the electrolytics while shifting the resonant frequency of the ceramics out-of-band.
Some series inductance between the DAC supply pins and the power supply plane often helps to filter out high frequency power supply noise. This inductance can be generated using a small ferrite bead as shown in Figure 20.

\section*{Reference Amplifier Considerations}

The reference input current buffer is a high performance amplifier optimized for high accuracy and linearity. The design of the reference amplifier ensures fast settling times by tightly control-
ling the node common to all the current sources internal to the DAC with an external compensation capacitor ( \(\mathrm{C}_{\text {COMP }}\) ). Since the primary design goal of the DAC16 is to achieve 16 -bit performance, proper operation of the reference amplifier requires a


Figure 20. Using a Ferrite Bead as a High Frequency Filter
\(47 \mu \mathrm{~F}\) tantalum electrolytic capacitor shunted by a \(0.1 \mu \mathrm{~F}\) ceramic capacitor, as shown in Figure 21. Increasing the capacitance at this node above the recommended values does not further reduce the analog transition current noise spikes at the output of the reference amplifier. Reducing the value of compensation, however, is not recommended as DAC linearity will degrade as a result. In most systems, the \(\mathrm{V}_{\mathrm{EE}}\) supply offers sufficiently low impedance to maintain a quiet return point for the reference amplifier. If this is not the case, the AGND point can also be used for the compensation capacitor return, as shown in Figure 21.


Figure 21a. Recommended Compensation Scheme to \(V_{E E}\)


Figure 21b. Recommended Compensation Schemeto AGND
In applications where 16-bit multiplying performance is required, the DAC16 might appear to be a viable solution. However, the compensation capacitor network would have to be removed in these applications. The DAC16's reference amplifier was specifically designed for low frequency operation, with a compensation canacitor network. In fact, this network serves not only as a charge reservoir for the DAC's internal current sources
but also as a wideband noise filter for the reference amplifier. Completely removing the compensation network would introduce large linearity errors, reference amplifier instability, wideband reference amplifier noise, and poor settling time.

Because the DAC exhibits an internal current scaling factor of eight times ( \(8 \times\) ), the reference amplifier requires only \(500 \mu \mathrm{~A}\) input current from the user-supplied precision reference for a 4 mA full-scale output current. In applications that do not require such high output currents, good accuracy can be achieved with input reference currents in the range of \(350 \mu \mathrm{~A}\) \(\leq \mathrm{I}_{\text {REF }} \leq 625 \mu \mathrm{~A}\). The best signal-to-noise ratios, of course, will be achieved with a \(625 \mu \mathrm{~A}\) reference current which yields a maximum 5 mA output current. Figure 22 illustrates how to form the reference input current with a REF02 and a \(10 \mathrm{k} \Omega\) precision resistor.


Figure 22. Generating the DAC16's Reference Input Current

\section*{Reducing Voltage Reference Noise}

In data converters of 16 -bit and greater resolution, noise is of critical importance. Surprisingly, the integrated voltage reference circuit used may contribute the dominant share of a system's noise floor, thereby degrading system dynamic range and signal-to-noise ratio. To maximize system dynamic range and SNR, all external noise contributions should be effectively much less than \(1 / 2\) LSB. For example, in a 5 V DAC16 application, one LSB is equivalent to \(76 \mu \mathrm{~V}\). This means that the total wideband noise contribution due to a voltage reference and all other sources should be less than \(38 \mu \mathrm{~V} \mathrm{rms}\). These noise levels are not easy targets to hit with standard off-the-shelf reference devices. For example, commercially available references might exhibit \(5 \mu \mathrm{~V}\) rms noise from 0.1 Hz to 10 Hz ; but, over a 100 kHz bandwidth, its \(300 \mu \mathrm{~V}\) rms of noise can easily swamp out a 16-bit system. Such noisy behavior can degrade a DAC's effective resolution by increasing its differential nonlinearity which, in turn, can lead to nonmonotonic behavior or analog errors.
The easiest way to reduce noise in the reference circuit is to band-limit its noise before feeding it to the converter. In the case of the DAC16, the reference is not a voltage, but a current. Illustrated in Figure 23 is a simple way of band-limiting


Figure 23. Filtering a Reference's Wideband Noise
voltage reference noise by splitting \(\mathrm{R}_{\mathrm{REF}}\) into two equal resistors and bypassing the common node with a capacitor. To minimize thermally induced errors, R1 and R2 must be electrically and thermally well-matched. Thin-film resistor networks work well here. In this circuit, the parallel combination of R1 and R2 forms a 3 Hz low pass filter with Cl . The only noise source that remains is the thermal noise of R 2 which can be a significantly lower noise generator than the voltage reference.

\section*{Input Coding}

The unipolar digital input coding of the DAC16 employs negative logic to control the output current; that is, an all zero input code \(\left(0000_{\mathrm{H}}\right)\) yields an output current 1 LSB below full scale. Conversely, an all 1s input code ( \(\mathrm{FFFF}_{\mathrm{H}}\) ) yields a zero analog current output. An expression for the DAC16's transfer equation can be expressed by:
\[
I_{O U T}=8 \times I_{R E F} \times\left[\frac{65,535-\text { Digital Code }}{65,536}\right]
\]

Table II provides the relationship between the digital input codes and the output current of the DAC16.

Table II. Unipolar Code Table
\begin{tabular}{l|l|l}
\hline \begin{tabular}{l} 
Digital Input \\
Word (Hex)
\end{tabular} & \begin{tabular}{l} 
DAC16 Output \\
Current \(\mathbf{I}_{\text {OUT }}\)
\end{tabular} & Comment \\
\hline 0000 & \(8 \times\left(2^{16}-1\right) / 2^{16} \times \mathrm{I}_{\text {REF }}\) & Full Scale \\
7FFE & \(8 \times\left(2^{15}+1\right) / 2^{16} \times \mathrm{I}_{\text {REF }}\) & Midscale +1 LSB \\
7FFF & \(8 \times\left(2^{15} / 2^{16}\right) \times \mathrm{I}_{\mathrm{REF}}\) & Midscale \\
8000 & \(8 \times\left(2^{15}-1\right) / 2^{16} \times \mathrm{I}_{\text {REF }}\) & Midscale -1 LSB \\
FFFF & 0 & Zero Scale \\
\hline
\end{tabular}

Since the DAC16 exhibits a small output voltage compliance on the order of a few millivolts, a high accuracy operational amplifier must be used to convert the DAC's output current to a voltage. Refer to the section on selecting operation amplifiers for the DAC16. The circuit shown in Figure 24 illustrates a unipolar output configuration. In symbolic form, the transfer equation for this circuit can be expressed by:
\[
V_{O}=R 3 \times 8 \times I_{R E F}\left[\frac{65,535-\text { Digital Code }}{65,536}\right]
\]

In this example, the reference input current was set to \(500 \mu \mathrm{~A}\) which produces a full-scale output current of \(4 \mathrm{~mA}-1\) LSB. The DAC's output current was scaled by R3, a \(1.25 \mathrm{k} \Omega\) resistor, to produce a 5 V full-scale output voltage. Bear in mind that to ensure the highest possible accuracy, matched thin-film resistor networks are almost a necessity, not an option. The resistors used in the circuit must have close tolerance and tight thermal tracking. Table III illustrates the relationship between the input digital code and the circuit's output voltage for the component values shown.

Table III. Unipolar Output Voltage vs. Digital Input Code
\begin{tabular}{l|l|l}
\hline \begin{tabular}{l} 
Digital Input Word \\
(Hex)
\end{tabular} & \begin{tabular}{l} 
Decimal Number in \\
in DAC Decoder
\end{tabular} & \begin{tabular}{l} 
Analog Output \\
Voltage (V)
\end{tabular} \\
\hline 0000 & 65,535 & 4.999924 \\
7 FFE & 32,769 & 2.500076 \\
7FFF & 32,768 & 2.500000 \\
8000 & 32,767 & 2.499924 \\
FFFF & 0 & 0 \\
\hline
\end{tabular}


Figure 24. Unipolar Circuit Configuration


Figure 25. Bipolar Circuit Configuration

\section*{Bipolar Configuration}

For applications that require a bipolar output voltage, the circuit in Figure 24 can be modified slightly by adding a resistor from the reference to the inverting sum node of the output amplifier to level shift the output signal. The transfer equation for the circuit now becomes:
\[
V_{O}=R 4 \times 8 \times I_{R E F}\left[\frac{65,535-\text { Digital Code }}{65,536}\right]-V_{R E F} \times\left(\frac{R 4}{R 3}\right)
\]

The circuit has the form shown in Figure 25, and Table IV provides the relationship between the digital input code and the circuit's output voltage for the component values shown.

Table IV. Bipolar Output Operation vs. Digital Input Code
\begin{tabular}{l|l|l}
\hline \begin{tabular}{l} 
Digital Input \\
Word (Hex)
\end{tabular} & \begin{tabular}{l} 
Decimal Number in \\
DAC Decoder
\end{tabular} & \begin{tabular}{l} 
Analog Output \\
Voltage (V)
\end{tabular} \\
\hline 0000 & 65,535 & 4.999848 \\
7 FFE & 32,769 & \(152 \mathrm{E}-6\) \\
7 FFF & 32,768 & 0 \\
8000 & 32,767 & \(-152 \mathrm{E}-6\) \\
FFFF & 0 & -5.00000 \\
\hline
\end{tabular}


Figure 26. DAC16 Noise Measurement Test Circuit

\section*{DAC16 Noise Performance}

The novel architecture employed in the DAC16 yields very low wideband noise. Figure 26 illustrates the circuit configuration for evaluating the DAC16's noise performance. An OP27 is used as the DAC16's output I-V converter which is configured to produce a 5 V full-scale output voltage. The output of the OP27 was then capacitively coupled to an OP37 stage configured in a gain of 101 . Note that the techniques for reducing wideband noise of the voltage reference and the DAC's internal reference amplifier were used. As a result of these techniques, the DAC16 exhibited a full-scale output noise spectral density of 31 \(\mathrm{pA} / \sqrt{\mathrm{Hz}}\) at 1 kHz .

\section*{Digital Feedthrough and Data Skew}

The DAC16 features a compound DAC architecture where the 5 most significant bits utilize 31 identical, segmented current sources to obtain optimal high speed settling at major code transitions. Although every effort has been made to equalize the speeds at which the DAC switches operate, there exists finite skew in the MSB DAC switches.
As with any converter product, a high speed digital-to-analog converter is forced to exist on the frontier between the noisy environment of high speed digital logic and the sensitive analog domain. The problems of this interface are particularly acute when demands of high speed (greater than 10 MHz switching times) and high precision are combined. No amount of design effort can perfectly isolate the analog portions of a DAC from the spectral components of a digital input signal with a 2 ns rise time. Inevitably, once this digital signal is brought onto the chip, some of its higher frequency components will find their way to the sensitive analog nodes, producing a digital feedthrough glitch. To minimize the exposure to this effect, the DAC16 was designed to omit intentionally the on-board latches that are usually included in many slower DACs. This not only reduces the overall level of digital activity on chip, it also avoids bringing a latch clock pulse onto the IC, whose opposite edge inevitably produces a substantial glitch, even when the DAC is not supposed to be changing codes.

The DAC16 uses each digital input line to switch each current segment in the DAC between the output diode-connected transistor and the logic control transistor. If the input bits are not changed simultaneously, or if the different DAC bits switch at different speeds, then the DAC output current will momentarily take on some incorrect value. This effect is particularly troublesome at the "carry points," where the DAC output is to change by only one LSB, but several of the larger current sources must be switched to realize this change. Data skew can allow the DAC output to move a substantial amount towards full scale or zero (depending upon the direction of the skew) when only a small transition is desired. The glitch-sensitive user should be equally diligent about minimizing the data skew at the DAC16's inputs, particularly the five most significant bits. This can be achieved by using the proper logic family and gate to drive the DAC inputs, and keeping the interconnect lines between the latches and the DAC inputs as short and as well matched as possible. Logic families that were empirically determined to operate well with the DAC16 are devices from the 74AC11XXX and 74ACT11XXX advanced CMOS logic families. These devices have been purposely designed with improved layout and tailored rise times for minimizing ground bounce and digital feedthrough.

\section*{Deglitching}

The output glitch of the DAC16 at the major carry \(\left(7 \mathrm{FFE}_{\mathrm{H}}\right.\) to \(7 \mathrm{FFF}_{\mathrm{H}}\) ) is a not-insignificant \(360 \mathrm{pA}-\mathrm{sec}\), manifested as a momentary output transition to the negative rail for approximately 200 ns . Due to the inherent low-pass or time-sampled nature of many systems, this behavior in the DAC16 is not noticeable and does not detract from overall performance. Some applications however may prove so sensitive to glitch impulse that reduction by an order of magnitude or more is required. In order to realize low glitch impulses, some sort of sample-andhold amplifier-based deglitching scheme must be used.

There are high speed SHAs available with specifications sufficient to deglitch the DAC16; however, most are hybrid in topology at costs which can be prohibitive. A high performance, low cost alternative shown in Figure 27 is a discrete SHA utilizing a high speed monolithic op amp and high speed DMOS FET switches.
This SHA circuit uses the inverting integrator structure. A 300 MHz gain-bandwidth product op amp, the AD841, is the heart of this fast SHA. The time constant formed by the \(200 \Omega\) resistor and the 100 pF capacitor determines the acquisition time and also band limits the output signal to eliminate slewinduced distortion.
A discrete drive circuit is used to achieve the best performance from the SD5000 quad DMOS switch. This switch-driving cell is composed of MPS571 RF NPN transistors and an MC10124 TTL-to-ECL translator. Using this technique provides both high speed and highly symmetrical drive signals for the SD5000 switches. The switches are arranged in a single-pole, doublethrow (SPDT) configuration. The 500 pF "flyback" capacitor is switched to the op amp summing junction during the hold mode to keep switching transients from feeding to the output. This capacitor is grounded during sample mode to minimize its effect on acquisition time.
Careful circuit layout of the high speed SHA section is almost as important as the design itself. Double-sided printed circuit board, a compact layout, and short critical signal paths all ensure best performance.

\section*{Op Amp Selection}

When selecting the amplifier to be used for the DAC16's I-V converter, there are two main application areas; those requiring high accuracy, and those seeking high speed. In high accuracy applications, three parameters are of prime importance: (1) input offset voltage, \(\mathrm{V}_{\mathrm{OS}}\); (2) input bias current, \(-\mathrm{I}_{\mathrm{B}}\); and (3) offset voltage drift, \(\mathrm{TCV}_{\text {Os }}\). In these applications where 16-bit
performance must be maintained with an external reference at +5 V , an op amp's input offset voltage must be less than \(15 \mu \mathrm{~V}\) \((\approx 0.1 \mathrm{LSB}\) ) with a bias current less than 6 nA . The op amp must also exhibit high open-loop gain to keep the offset voltage below this limit over the specified full-scale output range. Thus, for an maximum output of 5 V , the op amp's open loop gain must be greater than \(1300 \mathrm{~V} / \mathrm{mV}\).
For low frequency, high accuracy applications, Table IV lists selected compatible operational amplifiers available from Analog Devices. These operational amplifiers satisfy all the above requirements and in most all cases will not require offset voltage nulling.

Table V. Precision Operational Amplifiers for the DAC16
\begin{tabular}{l|l|l|l|l}
\hline Model & \(\mathbf{V}_{\text {Os }}\) & \(\mathbf{T C V}_{\text {OS }}\) & \(\mathbf{I}_{\mathbf{B}}\) & \(\mathbf{A}_{\text {voL }}\) \\
\hline OP177 & \(10 \mu \mathrm{~V}\) & \(0.3 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}\) & 2 nA & \(12000 \mathrm{~V} / \mathrm{mV}\) \\
OP77 & \(25 \mu \mathrm{~V}\) & \(0.6 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}\) & 2.8 nA & \(2000 \mathrm{~V} / \mathrm{mV}\) \\
OP27 & \(25 \mu \mathrm{~V}\) & \(0.2 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}\) & 80 nA & \(1500 \mathrm{~V} / \mathrm{mV}\) \\
OP97 & \(25 \mu \mathrm{~V}\) & \(2 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}\) & 0.15 nA & \(2000 \mathrm{~V} / \mathrm{mV}\) \\
\hline
\end{tabular}

In high speed applications where resolution is more important than absolute accuracy, operational amplifiers such as the AD843 offer the requisite settling time. Although these amplifiers are not specified for 16-bit performance, their settling times are two to three times faster than the DAC16 and will introduce negligible error to the overall circuit's settling time. It is possible to estimate the 16 -bit settling time of an operational amplifier if its 12 -bit settling time is known. Assuming that the op amp can be modeled by a single-pole response, then the ratio of the op amp's 16 -bit settling time to its 12 -bit settling can be expressed as:
\[
\frac{t_{S}(16-b i t)}{t_{S}(12-b i t)}=1.33
\]


Figure 27. A High Performance Deglitching Circuit

Since many operational amplifier data sheets provide charts illustrating \(0.01 \%\) settling time versus output voltage step size, all that is required to estimate an op amp's 16 -bit settling time is to multiply the 12 -bit settling time for the required full-scale voltage by 1.33 . The circuit's overall settling time can then be approximated by the root-sum-square method:
\[
t_{S}=\sqrt{\left(t_{D A C}\right)^{2}+\left(t_{O A}\right)^{2}}
\]
where
\(\mathrm{t}_{\text {DAC }}=\) DACl6's specified full-scale settling time
\(\mathrm{t}_{\mathrm{OA}}=\mathrm{Op}\) amp full-scale settling time
As a design aid, Table VI illustrates a high speed operational amplifier selector guide for devices compatible with the DAC16 for high speed applications. All these devices exhibit the requisite settling time, input offset voltage, and input bias current consistent with maximum performance.

Table VI. High Speed Operational Amplifiers for the DAC16
\begin{tabular}{l|l|l|l|l|l}
\hline Model & \(\mathbf{t}_{\mathbf{s}}\) to \(\%\) & \(\mathbf{V}_{\text {os }}\) & \(\mathbf{T C V}_{\text {os }}\) & \(\mathbf{I}_{\mathbf{B}}\) & \(\mathbf{A}_{\text {voL }}\) \\
\hline OP467 & \(200 \mathrm{~ns}-0.01\) & 0.5 mV & \(3.5 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}\) & \(0.5 \mu \mathrm{~A}\) & \(20 \mathrm{~V} / \mathrm{mV}\) \\
AD817 & \(70 \mathrm{~ns}-0.01\) & 2 mV & \(10 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}\) & \(6.6 \mu \mathrm{~A}\) & \(6 \mathrm{~V} / \mathrm{mV}\) \\
AD829 & \(90 \mathrm{~ns}-0.1\) & 0.5 mV & \(0.3 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}\) & \(7 \mu \mathrm{~A}\) & \(100 \mathrm{~V} / \mathrm{mV}\) \\
AD841 & \(110 \mathrm{~ns}-0.01\) & 1 mV & \(35 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}\) & \(5 \mu \mathrm{~A}\) & \(45 \mathrm{~V} / \mathrm{mV}\) \\
AD843 & \(135 \mathrm{~ns}-0.01\) & 1 mV & \(12 \mu V /{ }^{\circ} \mathrm{C}\) & \(0.001 \mu \mathrm{~A}\) & \(25 \mathrm{~V} / \mathrm{mV}\) \\
AD845 & \(350 \mathrm{~ns}-0.01\) & 0.25 mV & \(5 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}\) & \(0.001 \mu \mathrm{~A}\) & \(500 \mathrm{~V} / \mathrm{mV}\) \\
AD847 & \(120 \mathrm{~ns}-0.01\) & 1 mV & \(15 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}\) & \(5 \mu \mathrm{~A}\) & \(5.5 \mathrm{~V} / \mathrm{mV}\) \\
\hline
\end{tabular}

In using high speed op amps, the output capacitance of the DAC16 appears across the inputs of the op amp where it and the op amp's input capacitance will set an additional pole in the op amp's loop gain response. The pole is formed with the feedback resistance and the output resistance of the DAC. This additional pole may adversely affect the transient response of the circuit due to the added phase shift. Placing a small capacitor across the feedback resistance, as shown in Figure 28, compensates for the additional pole. The value of the capacitor can be determined by setting \(\mathrm{R}_{\mathrm{FB}} \mathrm{C}_{\mathrm{FB}}=\mathrm{R}_{\mathrm{O}}\left(\mathrm{C}_{\mathrm{O}}+\mathrm{C}_{\mathrm{IN}}\right)\) and should be adjusted for optimum transient response.
The choice of amplifier depends entirely on the required system accuracy, the required temperature range, and the operating frequency.


Figure 28. Compensating for the Feedback Pole

\title{
12-Bit High Speed Multiplying D/A Converter
}

\section*{DAC312}

\section*{FEATURES}
- Differential Nonlinearity .......................... . \(\pm\) 1/2LSB
- Nonlinearity . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 0.05\%
- Fast Settling Time . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 250ns
- High Compliance ............................ -5 V to +10 V
- Differential Outputs ................................. . 0 to 4mA
- Guaranteed Monotonicity ........................... . . 12 Bits
- Low Full-Scale Tempco ........................ . 10ppm/ \({ }^{\circ} \mathrm{C}\)
- Circuit Interface to TTL, CMOS, ECL, PMOS/NMOS
- Low Power Consumption 225mW
- Industry Standard AM6012 Pinout
- Available in Die Form

ORDERING INFORMATION \({ }^{\dagger}\)
\begin{tabular}{|c|c|c|c|}
\hline \multirow[b]{2}{*}{DNL} & \multicolumn{2}{|c|}{PACKAGE} & \multirow[t]{2}{*}{OPERATING TEMPERATURE RANGE} \\
\hline & \[
\begin{aligned}
& \hline \text { CERDIP } \\
& \text { 20-PIN }
\end{aligned}
\] & PLASTIC
20-PIN & \\
\hline \(\pm 1 / 2\) LSB & DAC312ER* & - & COM \\
\hline \(\pm 1\) LSB & DAC312FR & - & XIND \\
\hline \(\pm 1\) LSB & DAC312HR & - & XIND \\
\hline \(\pm 1\) LSB & - & DAC312HP & XIND \\
\hline \(\pm 1\) LSB & - & DAC312HS & XIND \\
\hline
\end{tabular}
- For devices processed in total compliance to MIL-STD-883, add/883 after part number. Consult factory for 883 data sheet.
\(\dagger\) Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.

\section*{GENERAL DESCRIPTION}

The DAC-312 series of 12-bit multiplying digital-to-analog converters provide high speed with guaranteed performance to \(0.012 \%\) differential nonlinearity over the full commercial operating temperature range.

Based on the segmented design approach pioneered by PMI with the COMDAC® line of data converters, the DAC-312 combines a 9-bit master D/A converter with a 3-bit (MSB's) segment generator to form an accurate 12-bit D/A converter at low cost. This technique guarantees a very uniform step size (up to \(\pm 1 / 2\) LSB from the ideal), monotonicity to 12 bits and integral nonlinearity to \(0.05 \%\) at its differential current outputs. In order to provide the same performance with a 12-bit R-2R ladder design, an integral nonlinearity over temperature of \(1 / 2\) LSB \((0.012 \%)\) would be required.

The 250ns settling time with low glitch energy and low power consumption are achieved by careful attention to the circuit design and stringent process controls. Direct interface with all popular logic families is achieved through the logic threshold terminal.

PIN CONNECTIONS


\section*{FUNCTIONAL DIAGRAM}


\footnotetext{
This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.
}

\section*{DAC312}

High compliance and low drift characteristics (as low as \(10 \mathrm{ppm} /{ }^{\circ} \mathrm{C}\) ) are also features of the DAC-312 along with an excellent power supply rejection ratio of \(\pm .001 \% \mathrm{FS} / \% \Delta \mathrm{~V}\). Operating over a power supply range of \(+5 /-11 \mathrm{~V}\) to \(\pm 18 \mathrm{~V}\) the device consumes 225 mW at the lower supply voltages with an absolute maximum dissipation of 375 mW at the higher supply levels.

With their guaranteed specifications, single chip reliability and low cost, the DAC-312 device makes excellent building blocks for A/D converters, data acquisition systems, video display drivers, programmable test equipment and other applications where low power consumption and complete input/output versatility are required.

\section*{ABSOLUTE MAXIMUM RATINGS (Note 1)}

Operating Temperature
```

    DAC-312E
    ```
\(\qquad\)
\(\qquad\)
    DAC-312F, DAC-312H ............................-40.-. 
Junction Temperature ............................. -65'⿳ to +150}\mp@subsup{0}{}{\circ}\textrm{C
Storage Temperature (T) ..........................-65'C to +125
```

Lead Temperature (Soldering, $60 \mathbf{~ s e c}$ ) ..... $300^{\circ} \mathrm{C}$
Power Supply Voltage ..... $\pm 18 \mathrm{~V}$
Logic Inputs ..... -5 V to +18 V
Analog Current Outputs ..... -8 V to +12 V
Reference Inputs $V_{14}, V_{15}$ ..... V - to $\mathrm{V}+$
Reference Input Differential Voltage ( $\mathrm{V}_{14}, \mathrm{~V}_{15}$ ) ..... $\pm 18 \mathrm{~V}$
Reference Input Current ( $\left.\right|_{14}$ ) ..... 1.25 mA

| PACKAGE TYPE | $\boldsymbol{\theta}_{\mathrm{j}}($ Note 2) | $\theta_{\mathrm{jc}}$ | UNITS |
| :---: | :---: | :---: | :---: |
| 20 -Pin Hermetic DIP (R) | 76 | 11 | ${ }^{\circ} \mathrm{C} / \mathrm{N}$ |
| 20-Pin Plastic DIP (P) | 69 | 27 | ${ }^{\circ} \mathrm{CN}$ |
| 20-Pin SOL (S) | 88 | 25 | ${ }^{\circ} \mathrm{CN}$ |

## NOTES:

1. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
2. $\Theta_{\mid A}$ is specified for worst case mounting conditions, i.e., $\Theta_{\mid A}$ is specified for device in socket for CerDIP and P-DIP packages; $\boldsymbol{\theta}_{\mathrm{JA}}$ is specified for device soldered to printed circuit board for SOL package.

ELECTRICAL CHARACTERISTICS at $V_{S}= \pm 15 \mathrm{~V}, I_{\text {REF }}=1.0 \mathrm{~mA}, 0^{\circ} \mathrm{C} \leq T_{A} \leq 70^{\circ} \mathrm{C}$ for DAC-312E and $-40^{\circ} \mathrm{C} \leq T_{A} \leq+85^{\circ} \mathrm{C}$ for DAC$312 \mathrm{~F}, \mathrm{DAC}-312 \mathrm{H}$, unless otherwise noted. Output characteristics refer to both $\mathrm{I}_{\text {OUT }}$ and $\mathrm{I}_{\mathrm{OUT}}$.

| PARAMETER | SYMBOL | CONDITIONS |  | DAC-312E |  |  | DAC-312F |  |  | DAC-312H |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Resolution |  |  |  | 12 | - | - | 12 | . - | - | 12 | - | - | Bits |
| Monotonicity |  |  |  | 12 | - | - | 12 | - | - | 12 | - | - | Bits |
| Differential Nonlinearity | DNL | Deviation from ideal step size (Note 2) |  | - | - | $\begin{array}{r}  \pm 0.0125 \\ \pm 0.5 \end{array}$ | - | - | $\begin{array}{r}  \pm 0.0250 \\ \pm 1 \end{array}$ | - | - | $\begin{array}{r}  \pm 0.0250 \\ \pm 1 \end{array}$ | \%FS <br> LSB |
| Nonlinearity | INL | Deviation from ideal straight line (Note 2) |  | - | - | $\pm 0.05$ | - | - | $\pm 0.05$ | - | - | $\pm 0.05$ | \%FS |
| Full-Scale Current | $I_{\text {fS }}$ | $\begin{aligned} & V_{R E F}=10.000 \mathrm{~V} \\ & R_{14}=R_{15}=10.000 \mathrm{k} \Omega \\ & \text { (Note 2) } \end{aligned}$ |  | 3.967 | 3.999 | 4.031 | 3.935 | 3.999 | 4.063 | 3.935 | 3.999 | 4.063 | mA |
| Full-Scale Tempco | $\mathrm{TCl}_{\mathrm{FS}}$ |  |  | - | $\begin{array}{r}  \pm 5 \\ \pm 0.005 \end{array}$ | $\begin{array}{r}  \pm 20 \\ \pm 0.002 \end{array}$ | - | $\begin{array}{r}  \pm 10 \\ \pm 0.001 \end{array}$ | $\begin{array}{r}  \pm 40 \\ \pm 0.004 \end{array}$ | - | $\begin{array}{r}  \pm 80 \\ \pm 0.008 \end{array}$ | - | $\begin{aligned} & \mathrm{ppm} /{ }^{\circ} \mathrm{C} \\ & \% \mathrm{FS} /{ }^{\circ} \mathrm{C} \end{aligned}$ |
| Output Voltage Compliance | $V_{\text {OC }}$ | DNL Specification guaranteed over compliance range |  | $\cdots$ | - | $+10$ | -5 | - | +10 | -5 | - | +10 | V |
| Full-Scale Symmetry | $I_{\text {fSS }}$ | $\left\|I_{\text {FS }}\right\|-\left\|\left.\right\|_{\text {FS }}\right\|$ |  | - | $\pm 0.4$ | $\pm 1$ | - | $\pm 0.4$ | $\pm 2$ | - | $\pm 0.4$ | $\pm 2$ | $\mu \mathrm{A}$ |
| Zero-Scale Current | Izs |  |  | : - | - | 0.10 | - | - | 0.10 | - | - | 0.10 | $\mu \mathrm{A}$ |
| Settling Time | ${ }^{\text {t }}$ | To $\pm 1 / 2$ LSB, all bits switched ON or OFF (Note 1) |  | - | 250 | 500 | - | 250 | 500 | - | 250 | 500 | ns |
| Propagation Delay all bits | $t_{\text {PLH }}$ <br> ${ }^{\mathbf{t}_{\text {PHL }}}$ | All bits switched 50\% point logic swing tō 50\% pōint output (Note 1) |  | - | 25 | 50 | - | 25 | 50 | - | 25 | 50 | ns |
| Output Resistance | $R_{0}$ |  |  | - | $>10$ | - | - | $>10$. | - | - | >10 | - | $\mathrm{M} \Omega$ |
| Output Capacitance | $\mathrm{C}_{\text {OUt }}$ |  |  | - | 20 | - | - | 20 | - | - | 20 | - | pF |

ELECTRICAL CHARACTERISTICS at $V_{S}= \pm 15 \mathrm{~V}, \mathrm{I}_{\text {REF }}=1.0 \mathrm{~mA}, 0^{\circ} \mathrm{C} \leq \mathrm{T}_{A} \leq 70^{\circ} \mathrm{C}$ for DAC- 312 E and $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{A} \leq+85^{\circ} \mathrm{C}$ for DAC312F, DAC-312H, unless otherwise noted. Output characteristics refer to both $\mathrm{I}_{\text {OUT }}$ and $\overline{\mathrm{I}_{\text {OUT }}}$. Continued

| PARAMETER | SYMBOL | CONDITIONS | DAC-312E |  |  | DAC-312F |  |  | DAC-312H |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Logic Input Levels "0" | $V_{\text {IL }}$ | $\mathrm{V}_{\mathrm{LC}}=\mathrm{GND}$ | - | - | 0.8 | - | - | 0.8 | - | - | 0.8 | v |
| Logic input Levels " 1 " | $V_{1 H}$ | $\mathrm{V}_{\mathrm{LC}}=\mathrm{GND}$ | 2 | - | - | 2 | - | - | 2 | - | - | V |
| Logic Input Current | 1 IN | $V_{\text {IN }}=-5$ to +18 V | - | - | 40 | - | - | 40 | - | - | 40 | $\mu \mathrm{A}$ |
| Logic Input Swing | $V_{\text {IS }}$ |  | -5 | - | +18 | -5 | - | +18 | -5 | - | +18 | V |
| Reference Bias Current | $I_{15}$ |  | 0 | -0.5 | -2 | 0 | -0.5 | -2 | 0 | -0.5 | -2 | $\mu \mathrm{A}$ |
| Reference Input Slew Rate | $\mathrm{dl} / \mathrm{dt}$ | $\begin{aligned} & R_{14(\mathrm{eq})}=800 \Omega \\ & C_{C}=0 p F(\text { Note } 1) \end{aligned}$ | 4 | 8 | - | 4 | 8 | - | 4 | 8 | - | $\mathrm{mA} / \mu \mathrm{S}$ |
| Power Supply Sensitivity | $\begin{aligned} & \text { PSSI }_{\mathrm{FS}+} \\ & \text { PSSI }_{\mathrm{FS}}- \end{aligned}$ | $\begin{aligned} & \mathrm{V}+=+13.5 \mathrm{~V} \text { to }+16.5 \mathrm{~V} \\ & \mathrm{~V}-=-15 \mathrm{~V} \\ & \mathrm{~V}-=-13.5 \mathrm{~V} \text { to }-16.5 \mathrm{~V} \\ & \mathrm{~V}+=+15 \mathrm{~V} \end{aligned}$ |  |  |  |  |  | $\begin{aligned} & \pm 0.001 \\ & \pm 0.001 \end{aligned}$ |  | $\pm 0.0005$ 0.00025 | $\begin{aligned} & \pm 0.001 \\ & \pm 0.001 \end{aligned}$ | \%FS/\% $/$ V |
| Power Supply Range | $\begin{aligned} & \text { V+ } \\ & \text { V- } \end{aligned}$ | $V_{\text {OUT }}=0 \mathrm{~V}$ | $\begin{array}{r} 4.5 \\ -18 \end{array}$ | - | 18 -10.8 |  | - | $\begin{array}{r} 18 \\ -10.8 \end{array}$ | $\begin{array}{r} 4.5 \\ -18 \end{array}$ | - | $\begin{array}{r} 18 \\ -10.8 \end{array}$ | V |
| Power Supply Current | $1+$ $1-$ $1+$ $1-$ | $\begin{aligned} & \mathrm{V}+=+5 \mathrm{~V}, \mathrm{~V}-=-15 \mathrm{~V} \\ & \mathrm{~V}+=+15 \mathrm{~V}, \mathrm{~V}-=-15 \mathrm{~V} \end{aligned}$ | - | $\begin{array}{r} 3.3 \\ -13.9 \\ 3.9 \\ -13.9 \end{array}$ | 7 -18 7 -18 | - - - | $\begin{array}{r} 3.3 \\ -13.9 \\ 3.9 \\ -13.9 \\ \hline \end{array}$ | $\begin{array}{r}7 \\ -18 \\ 7 \\ -18 \\ \hline\end{array}$ | - | $\begin{array}{r}3.3 \\ -13.9 \\ 3.9 \\ -13.9 \\ \hline\end{array}$ | 7 -18 7 -18 | mA |
| Power Dissipation | $P_{d}$ | $\begin{aligned} & \mathrm{V}+=+5 \mathrm{~V}, \mathrm{~V}-=-15 \mathrm{~V} \\ & \mathrm{~V}+=+15 \mathrm{~V}, \mathrm{~V}-=-15 \mathrm{~V} \end{aligned}$ | - | 225 267 | 305 375 | - | 225 267 | $\begin{aligned} & 305 \\ & 375 \end{aligned}$ | - | 225 267 | 305 375 | mW |

## NOTES:

1. Guaranteed by design.
2. $T_{A}=25^{\circ} \mathrm{C}$ for $\mathrm{DAC}-312 \mathrm{H}$ grade only.

## FEATURES

- 12-Bit Accuracy in an 8-Pin Mini-Dip
- Fast Serial Data Input
- Double Data Buffers
- Low $\pm 1 / 2$ LSB Max INL and DNL
- Max Gain Error: $\pm 1$ LSB
- Low 5ppm/ ${ }^{\circ}$ C Max Tempco
- ESD Resistant
- Low Cost
- Available in Die Form


## APPLICATIONS

- Auto-Calibration Systems
- Process Control and Industrial Automation
- Programmable Amplifiers and Attenuators
- Digitally-Controlled Filters

ORDERING INFORMATION ${ }^{\dagger}$

| relative ACCURACY | PACKAGE |  |  |
| :---: | :---: | :---: | :---: |
|  | EXTENDED |  |  |
|  | MILTARY* | INDUSTRIAL | COMMERCIAL |
|  | TEMPERATURE | TEMPERATURE | TEMPERATURE |
|  | $-55^{\circ} \mathrm{CTO}+125^{\circ} \mathrm{C}$ | $-40^{\circ} \mathrm{C}$ TO $+85^{\circ} \mathrm{C}$ | $0^{\circ} \mathrm{C}$ TO $+70^{\circ} \mathrm{C}$ |
| $\pm 1 / 2$ LSB | DAC8043AZ | DAC8043EZ | DAC8043GP |
| $\pm 1 / 2$ LSB | DAC8043AZ883 | - | - |
| $\pm 1$ LSB | - - | DAC8043FZ | - |
| $\pm 1$ LSB | - | DAC8043FP | - |

- For devices processed in total compliance to MIL-STD-883, add/883 after part number. Consult factory for 883 data sheet.
$\dagger$ All commercial and industrial temperature range parts are available with burnin.


## PIN CONNECTIONS



8-PIN EPOXY DIP (P-Suffix)<br>8-PIN CERDIP (Z-Suffix)

## BURN-IN CIRCUIT



NOTES:
$R_{1}=10 \Omega$
$C_{1}=10 \mu F$
$C_{1}=10 \mu F$
$D_{1}=1$ N4001 OR EQUIVALENT
MAXIMUM POWER SUPPLY CURRENT PER DEVICE IS $+1.5 \mathrm{~mA}, \ldots \mathrm{~mA}$
POWER-UP SEQUENCE: $+5 \mathrm{~V},+10 \mathrm{~V}$
POWER-UP SEGUENCE: $+5 \mathrm{~V},+10 \mathrm{~V}$
POWER-DOWN SEQUENCE: $+10 \mathrm{~V},+5 \mathrm{~V}$

## GENERAL DESCRIPTION

The DAC-8043 is a high accuracy 12-bit CMOS multiplying DAC in a space-saving 8 -pin mini-DIP package. Featuring serial data input, double buffering, and excellent analog performance, the DAC-8043 is ideal for applications where PC board space is at a premium. Also, improved linearity and gain error performance permit reduced parts count through the elimination of trimming components. Separate input clock and load-DAC control lines allow full user control of data loading and analog output.
The circuit consists of a 12-bit serial-in, parallel-out shift register, a 12-bit DAC register, a 12-bit CMOS DAC, and control logic. Serial data is clocked into the input register on the rising edge of the CLOCK pulse. When the new data word has been clocked in, it is loaded into the DAC register with the $\overline{L D}$ input pin. Data in the DAC register is converted to an output current by the D/A converter.

The DAC-8043's fast interface timing may reduce timing design considerations while minimizing microprocessor wait states. For applications requiring an asynchronous CLEAR function or more versatile microprocessor interface logic, refer to the PM7543.

Operating from a single +5 V power supply, the DAC- 8043 is the ideal low power, small size, high performance solution to many application problems. It is available in plastic and cerdip packages that are compatible with auto-insertion equipment.

## FUNCTIONAL BLOCK DIAGRAM



## ABSOLUTE MAXIMUM RATINGS



| PACKAGE TYPE | $\Theta_{\text {IA }}$ (NOTE 1) | $\Theta_{\text {IC }}$ | UNITS |
| :--- | :---: | :---: | :---: |
| 8-Pin Hermetic DIP (Z) | 134 | 12 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin Plastic DIP $(P)$ | 96 | 37 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTE:

1. $\Theta_{i A}$ is specified for worst case mounting conditions, i.e., $\boldsymbol{\Theta}_{\mathrm{i} A}$ is specified for device in socket for CerDIP and P-DIP packages.

## CAUTION:

1. Do not apply voltages higher than $V_{D D}$ or less than GND potential on any terminal except $\mathrm{V}_{\mathrm{REF}}$ (Pin 1) and $\mathrm{R}_{\mathrm{FB}}(\operatorname{Pin} 2)$.
2. The digital control inputs are zener-protected; however, permanent damage may occur on unprotected units from high-energy electrostatic fields. Keep $\mathbf{3}$ units in conductive foam at all times until ready to use.
3. Use proper anti-static handling procedures.
4. Absolute Maximum Ratings apply to both packaged devices and DICE. Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V} ; \mathrm{V}_{\mathrm{REF}}=+10 \mathrm{~V} ; \mathrm{I}_{\mathrm{OUT}}=\mathrm{GND}=0 \mathrm{~V} ; \mathrm{T}_{\mathrm{A}}=$ Full Temperature Range specified under Absolute Maximum Ratings unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | MIN | DAC-80 TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| STATIC ACCURACY |  |  |  |  |  |  |
| Resolution | $N$ |  | 12 | - | - | Bits |
| Nonlinearity (Note 1) | INL | DAC-8043A/E/G DAC-8043F | - | - | $\begin{array}{r}  \pm 1 / 2 \\ 1 \end{array}$ | LSB |
| Differential Nonlinearity (Note 2) | DNL | DAC-8043A/E <br> DAC-8043F/G | - | - | $\begin{array}{r}  \pm 1 / 2 \\ \pm 1 \end{array}$ | LSB |
| Gain Error (Note 3) | $\mathbf{G F S E}^{\text {F }}$ | $\begin{aligned} & \mathrm{T}_{A}=+25^{\circ} \mathrm{C} \\ & \text { DAC-8043A/E } \\ & \text { DAC-8043F/G } \\ & \mathrm{T}_{\text {A }}=\text { Full Temperature Range } \\ & \text { All Grades } \end{aligned}$ | - | - - - | 1 2 2 | LSB |
| Gain Tempco <br> ( $\Delta$ Gains Temp) <br> (Note 5) | TC GFS |  | - | - | $\pm 5$ | ppm/ ${ }^{\circ} \mathrm{C}$ |
| Power Supply <br> Rejection Ratio ( $\Delta$ Gain $\Delta V_{D D}$ ) | PSRR | $\Delta V_{D D}= \pm 5 \%$ | - | $\pm 0.0006$ | $\pm 0.002$ | \%/\% |
| Output Leakage Current (Note 4) | $I_{\text {LKG }}$ | $\begin{aligned} & T_{A}=+25^{\circ} \mathrm{C} \\ & T_{A}=\text { Full Temperature Range } \\ & \text { DAC-8043A } \\ & \text { DAC-8043E/F/G } \end{aligned}$ | - - - | - - - | $\begin{array}{r}  \pm 5 \\ \pm 100 \\ \pm 25 \end{array}$ | $n \mathrm{~A}$ |
| Zero Scale Error (Notes 7, 12) | $I_{\text {zSE }}$ | $\begin{aligned} & T_{A}=+25^{\circ} \mathrm{C} \\ & T_{A}=\text { Full Temperature Range } \\ & \text { DAC-8043A } \\ & \text { DAC-8043E/F/G } \end{aligned}$ | - - - | - - - | $\begin{aligned} & 0.03 \\ & 0.61 \\ & 0.15 \end{aligned}$ | LSB |
| Input Resistance (Note 8) | $\mathrm{R}_{\text {IN }}$ | ' | 7 | 11 | 15 | k $\Omega$ |
| AC PERFORMANCE |  |  |  |  |  |  |
| Output Current Setting Time (Notes 5, 6) | $\mathrm{t}_{\mathbf{S}}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | - | 0.25 | 1 | $\boldsymbol{\mu s}$ |

## DAC8043

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V} ; \mathrm{V}_{\text {REF }}=+10 \mathrm{~V} ; \mathrm{I}_{\mathrm{OUT}}=\mathrm{GND}=\mathrm{V} ; \mathrm{T}_{\mathrm{A}}=$ Full Temperature Range specified under
Absolute Maximum Ratings unless otherwise noted. Continued

| Parameter | SYMBOL | CONDITIONS | DAC-8043 |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX |  |
| Digital to Analog Glitch Energy (Note 5,10) | Q | $\begin{aligned} & V_{\text {PEF }}=0 V \\ & \text { IOUT } \text { Load }=100 \Omega \\ & C_{\text {EXT }}=13 \mathrm{pF} \\ & \text { DAC register loaded alternately with } \\ & \text { all } 0 \text { s and all 1s } \\ & \hline \end{aligned}$ | - | 2 | 20 | nV8 |
| $\begin{aligned} & \hline \text { Feedthrough Error } \\ & \left.V_{\text {REE }} \text { to Iout }\right) \\ & (\text { Note 5, 11) } \\ & \hline \end{aligned}$ | FT | $\begin{aligned} & V_{\text {REF }}=20 \mathrm{~V}_{\text {p-p }} @ f=10 \mathrm{kHz} \\ & \text { Digital Input }=000000000000 \\ & T_{A}=+25^{\circ} \mathrm{C} \end{aligned}$ | - | 0.7 | 1 | $m V_{p-p}$ |
| Total Harmonic Distortion (Note 5) | THD | $\begin{aligned} & V_{\text {PEF }}=6 \mathrm{~V} \text { RMS @ } 1 \mathrm{kHz} \\ & \mathrm{DAC} \text { register loaded with all 1s } \end{aligned}$ | - | -85 | - | dB |
| Output Noise Voltage Density (Notes 5, 13) | $\mathrm{e}_{\mathrm{n}}$ | 10 Hz to 100 kHz between $\mathrm{R}_{\mathrm{FB}}$ and $\mathrm{I}_{\text {Out }}$ | - | - | 17 | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| DIGITAL INPUTS |  |  |  |  |  |  |
| Digital Input HIGH | $\mathrm{V}_{1 H}$ |  | 2.4 | - | - | v |
| Digital Input LOW | $V_{1 L}$ |  | - | - | 0.8 | V |
| Input Leakage Current (Note 9) | 1 IL | $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ to +5 V | - | - | $\pm 1$ | $\mu \mathrm{A}$ |
| Input Capacitance (Note 5, 11) | $\mathrm{C}_{1 \mathrm{~N}}$ | $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ | - | - | 8 | pF |

ANALOG OUTPUTS

| Output Capacitance (Note 5) | $\mathrm{C}_{\text {OUT }}$ | Digital Inputs $=\mathbf{V}_{\mathbf{I H}}$ | - | - | 110 | pF |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Digital Inputs $=\mathrm{V}_{1 \mathrm{~L}}$ | - | - | 80 |  |

TIMING CHARACTERISTICS (NOTES 5, 14)

| Data Setup Time | $\mathrm{t}_{\mathrm{DS}}$ | $T_{A}=$ Full Temperature Range | 40 | - | - | ns |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Data Hold Time | $\mathrm{t}_{\mathrm{DH}}$ | $\mathrm{T}_{\mathrm{A}}=$ Full Temperature Range | 80 | - | - | ns |
| Clock Pulse Width High | ${ }^{\mathrm{C}_{\mathrm{CH}}}$ | $T_{A}=$ Full Temperature Range | 90 | - | - | ns |
| Clock Pulse Width Low | ${ }^{\text {che }}$ | $T_{A}=$ Full Temperature Range | 120 | - | - | ns |
| Load Pulse Width | ${ }_{\text {L }}$ D | $T_{A}=$ Full Temperature Range | 120 | - | - | ns |
| LSB Clock Into Input Register to Load DAC Register Time | ${ }^{\text {t }}$ ASB | $\mathrm{T}_{\mathrm{A}}=$ Full Temperature Range | 0 | - | - | ns |
| POWER SUPPLY |  |  |  |  |  |  |
| Supply Voltage | $V_{\text {DD }}$ |  | 4.75 | 5 | 5.25 | v |
| Supply Current | 'do | $\begin{aligned} & \text { Digital Inputs }=V_{1 H} \text { or } V_{1 L} \\ & \text { Digital Inputs }=O V \text { or } V_{D D} \end{aligned}$ | - | - | $\begin{aligned} & 500 \\ & 100 \end{aligned}$ | $\mu \mathrm{MaX}$ |

## NOTES:

1. $\pm 1 / 2 \mathrm{LSB}= \pm 0.012 \%$ of Full Scale.
2. All grades are monotonic to 12 -bits over temperature.
3. Using internal feedback resistor.
4. Applies to $\mathrm{I}_{\text {OUT }}$; All digital inputs $=0 \mathrm{~V}$.
5. Guaranteed by design and not tested.
6. $I_{O U T}$ Load $=100 \Omega, C_{E X T}=13 p F$, digital input $=O V$ to $V_{D D}$ or $V_{D D}$ to $O V$. Extrapolated to $1 / 2$ LSB: $t_{S}=$ propagation delay $\left(t_{P D}\right)+9 \tau$ where $\tau=$ measured time constant of the final RC decay.
7. $V_{\text {REF }}=+10 \mathrm{~V}$, all digital inputs $=0 \mathrm{~V}$.
8. Absolute temperature coefficient is less than $+300 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$.
9. Digital inputs are CMOS gates; $I_{I N}$ is typically $1 n A$ at $+25^{\circ} \mathrm{C}$.
10. $\mathrm{V}_{\mathrm{REF}}=0 \mathrm{~V}$, all digital inputs $=0 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}$ or $\mathrm{V}_{\mathrm{DD}}$ to 0 V .
11. All digital inputs $=0 V$.
12. Calculated from worst case $R_{\text {REF }}$ :
$\mathrm{I}_{\mathrm{ZSE}}$ (in LSBs) $=\left(\mathrm{R}_{\text {REF }} \times \mathrm{I}_{\text {LKG }} \times 4096\right) N_{\text {REF }}$.
13. Calculations from en $=\sqrt{4 K}$ TRB where:
$K=$ Boltzmann constant, $J /{ }^{\circ} \mathrm{K}, \mathrm{R}=$ resistance, $\Omega$
$\mathrm{T}=$ resistor temperature, ${ }^{\circ} \mathrm{K}, \mathrm{B}=$ bandwidth, Hz
14. Tested at $\mathrm{V}_{\mathrm{IN}}=O \mathrm{~V}$ or $\mathrm{V}_{\mathrm{DD}}$. Dual 12-Bit Buffered

## FEATURES

- Two Matched 12-Bit DACs on One Chip
- Packaged in a Narrow 0.3" 24-Pin DIP
- Direct Parallel Load of All 12 Bits for High DataThroughput
- On-Chip Latches for Both DACs
- 12-Bit Endpont Linearity ( $\mathbf{\pm} 1 / 2$ LSB) Over Temperature
- +5 V to +15 V Single Supply Operation
- DACs Matched to 0.2\% Typically
- Four-Quadrant Multiplication
- Improved ESD Resistance
- Available in Die Form


## APPLICATIONS

- Automatic Test Equipment
- Industrial Automation
- Robotics/Process Control
- Programmable Instrumentation Equipment
- Digital Gain/Attenuation Control
- Ideal for Battery-Operated Equipment


## ORDERING INFORMATION ${ }^{\dagger}$

| relative ACCURACY ( +5 V or | GAIN ERROR 15V) | PACKAGE |  |  |
| :---: | :---: | :---: | :---: | :---: |
|  |  | MILITARY* <br> TEMPERATURE $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | INDUSTRIAL TEMPERATURE $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | COMMERCIAL TEMPERATURE $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ |
| $\pm 1 / 2$ LSB | $\pm 1$ LSB | DAC8221AW | DAC8221EW | - |
| $\pm 1 / 2$ LSB | $\pm 2$ LSB | - | - | DAC8221GP |
| $\pm 1$ LSB | $\pm 4$ LSB | - | DAC8221FW | DAC8221HP |
| $\pm 1$ LSB | $\pm 4$ LSB | - | DAC8221FP | DAC8221HSH |

* For devices processed in total compliance to MIL-SDT-883, add /883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.
tt For availability and burn-in information on SO and PLCC packages, contact your local sales office.


## GENERAL DESCRIPTION

The DAC-8221 combines two identical 12-bit, multiplying, digital-to-analog converters into a single CMOS chip. This device is electrically similar to DAC-8212 with improved microprocessor interface timing and is packaged in a narrow 0.300" DIP. Monolithic construction offers excellent DAC-to-DAC matching and tracking over the full operating temperature range. The DAC8221 consists of two thin-film R-2R resistor-ladder networks, two 12-bit data latches, one 12-bit input buffer, and control logic. The DAC-8221 operates on a single supply from +5 V to +15 V . Maximum power dissipation with OV and +5 V logic levels
and $a+5 \mathrm{~V}$ supply is less than 0.5 mW . The DAC-8221 is manufactured using PMI's highly-stable, thin-film resistors on an advanced oxide-isolated, silicon-gate, CMOS process. PMI's improved latch-up resistant design eliminates the need for external protective Schottky diodes.
A common 12-bit (TTL/CMOS compatible) input port is used to load a 12-bit-wide word into either of the two DACs. This port, whose data loading is similar to that of a RAM's write cycle, interfaces directly with most 12-bit or wider bus systems. With $\overline{W R}$ and $\overline{C S}$ lines at logic LOW, the input data registers are transparent. This allows direct unbuffered data to flow directly to the DAC output selected by $\overline{\text { DAC A }} / D A C B$ control input. For applications requiring double-buffering, see the DAC-8222.

## PIN CONNECTIONS



FUNCTIONAL DIAGRAM


## ABSOLUTE MAXIMUM RATINGS

| $V^{\text {to }}$ to ${ }^{\text {AGND }}$ | +17V |
| :---: | :---: |
| $V_{D D}$ to DGND | . $\mathrm{V},+17 \mathrm{~V}$ |
| AGND to DGND | -0.3V, $\mathrm{V}_{\mathrm{OD}}+0.3 \mathrm{~V}$ |
| Digital Input Voltage to DGND | $-0.3 \mathrm{~V}, \mathrm{~V}_{\text {DD }}+0.3 \mathrm{~V}$ |
| Iout A, I Out e to AGND | $-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| $V_{\text {REF A }}{ }^{\prime} V_{\text {REF } ~}$ to AGND | $\ldots . .25 \mathrm{~V}$ |
| $V_{\text {RFB A }}, \mathrm{V}_{\text {RFB B }}$ to AGND | ... $\pm 25 \mathrm{~V}$ |
| Operating Temperature Range |  |
| AW Version | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| EW, FW, FP Versions | . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| GP, HP, HS Versions | . $-0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ |
| Junction Temperature | ...... +150C |
| Storage Temperature | . $65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Lead Temperature (Solderin | $\ldots . .300^{\circ} \mathrm{C}$ |


| PACKAGE TYPE | $\theta_{\text {JA }}$ (NOTE 1) | $\boldsymbol{\theta}_{\boldsymbol{\prime} \mathrm{c}}$ | UNITS |
| :--- | :---: | :---: | :---: |
| 24-Pin Hermetic DIP (W) | 69 | 10 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 24-Pin Plastic DIP (P) | 62 | 32 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 24-Pin SOL (S) | 72 | 24 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTE:

1. $\Theta_{j A}$ is specified for worst case mounting conditions, i.e., $\Theta_{\mid A}$ is specified for device in socket for CerDIP, and P-DIP packages; $\Theta_{\mathrm{JA}}$ is specified for device soldered to printed circuit board for SOL package.

## CAUTION:

1. Do no apply voltages higher than $V_{D D}$ or less than GND potential on any terminal except $V_{\text {REF }}$ and $R_{\text {FB }}$.
2. The digital control inputs are zener-protected; however, permanent damage may occur on unprotected units from high-energy electrostatic fields. Keep units in conductive foam at all times until ready to use.
3. Do not insert this device into powered sockets; remove power before insertion or removal.
4. Use proper anti-static handling procedures.
5. Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation at or above this specification is not implied.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\text {DD }}=+5 \mathrm{~V}$ or $+15 \mathrm{~V}, \mathrm{~V}_{\text {REF }}=\mathrm{V}_{\text {REF } B}=+10 \mathrm{~V}, \mathrm{~V}_{\text {OUTA }}=\mathrm{V}_{\text {OUT }}=0 \mathrm{~V}$; AGND $=\mathrm{DGND}=0 \mathrm{~V}$; $T_{A}=$ Full Temp. Range specified in Absolute Maximum Ratings; unless otherwise noted. Specifications apply for DAC A and DAC B.

| PARAMETER | SYMBOL | CONDITIONS |  | DAC-8221 |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | MIN | TYP | MAX |  |
| STATIC ACCURACY |  |  |  |  |  |  |  |
| Resolution . | N |  |  | 12 | - | - | Bits |
| Relative Accuracy | INL | Endpoint Linearity Error | DAC-8221A/E/G DAC-8221B/F/H | - | $\begin{aligned} & \pm 0.2 \\ & \pm 0.4 \end{aligned}$ | $\begin{gathered} \pm 1 / 2 \\ \quad \pm 1 . \end{gathered}$ | LSB |
| Differential Nonlinearity | DNL | All Grades are Monotonic |  | - | $\pm 0.2$ | $\pm 1$ | LSB |
| Full Scale Gain Error (Note 1) | $\mathrm{G}_{\text {FSE }}$ | $\begin{aligned} & \text { DAC-8221AEE } \\ & \text { DAC-8221G } \\ & \text { DAC-8221B/F/H } \end{aligned}$ |  | - | $\begin{aligned} & \pm 0.1 \\ & \pm 0.4 \\ & \pm 0.6 \end{aligned}$ | $\begin{aligned} & \pm 1 \\ & \pm 2 \\ & \pm 4 \end{aligned}$ | LSB |
| Gain Temperature <br> Coefficient $\Delta$ Gain/ $\Delta$ Temperature | TCG ${ }_{\text {F }}$ | (Notes 2, 7) |  | - | $\pm 2$ | $\pm 5$ | ppm/ ${ }^{\circ} \mathrm{C}$ |
| Output Leakage Current $\begin{aligned} & \text { lout A }(\text { Pin 2), } \\ & \text { Iout B } \text { (Pin 24) } \end{aligned}$ | 'LKG | All Digital Inputs $=$ 000000000000 | $\begin{aligned} & T_{A}=+25^{\circ} \mathrm{C} \\ & T_{A}=\text { Full Temp. Range } \end{aligned}$ | - | $\begin{aligned} & \pm 1 \\ & \pm 2 \end{aligned}$ | $\begin{aligned} & \pm 10 \\ & \pm 50 \end{aligned}$ | nA |
| Input Resistance $\left(R_{\text {REF A }}, R_{\text {REF B }}\right)$ | $\mathrm{R}_{\text {REF }}$ | (Note 9) |  | 8 | 22 | 15 | k $\boldsymbol{\Omega}$ |
| Input Resistance Match $\left(R_{\text {REF A }} R_{\text {REF } B}\right)$ | $\frac{\Delta R_{\mathrm{REF}}}{\mathrm{R}_{\mathrm{REF}}}$ |  |  | - | $\pm 0.2$ | $\pm 1$ | \% |
| DIGITAL INPUTS |  |  |  |  |  |  |  |
| Digital Input High | $\mathrm{V}_{\text {INH }}$ | $\begin{aligned} & V_{D D}=+5 V \\ & V_{D D}=+15 \mathrm{~V} \end{aligned}$ | - | $\begin{array}{r} 2.4 \\ 13.5 \end{array}$ | - | - | V |
| Digital Input Low | $V_{\text {INL }}$ | $\begin{aligned} & V_{D D}=+5 \mathrm{~V} \\ & V_{D D}=+15 \mathrm{~V} \end{aligned}$ |  | - | - | 0.8 1.5 | V |
| Input Current | $I_{\text {IN }}$ | $\begin{aligned} & V_{I N}=O V \text { or } V_{D D} \\ & \text { and } V_{I N L} \text { or } V_{I N H} \end{aligned}$ | $\begin{aligned} & T_{A}=+25^{\circ} \mathrm{C} \\ & T_{A}=\text { Full Temp. Range } \end{aligned}$ | - | $\begin{array}{r}  \pm 0.006 \\ \pm 0.1 \end{array}$ | $\begin{array}{r}  \pm 1 \\ \pm 10 \end{array}$ | $\mu \mathrm{A}$ |
| Input Capacitance (Note 2) | $C_{\text {IN }}$ | DB0 - DB11 <br> $\overline{W R}, \overline{C S}, \overline{D A C A} / D A C B$ |  | - | - | 10 15 | pF |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V}$ or $+15 \mathrm{~V}, \mathrm{~V}_{\text {REFA }}=\mathrm{V}_{\text {REF } B}=+10 \mathrm{~V}, \mathrm{~V}_{\text {OUTA }}=\mathrm{V}_{\text {OUT } B}=0 \mathrm{~V}$; AGND $=\mathrm{DGND}=0 \mathrm{~V}$; $T_{A}=$ Full Temp Range specified in Absolute Maximum Ratings; unless otherwise noted. Specifications apply for DAC A and DAC B. Continued



## FEATURES

- Two Matched 12-Bit DACs on One Chip
- Direct Parallel Load of All 12 Bits for High Data Throughput
- Double-Buffered Digital Inputs
- 12-Bit Endpont Linearity ( $\mathbf{1} 1 / 2$ LSB) Over Temperature
- +5 V to +15 V Single Supply Operation
- DACs Matched to 1\% Max
- Four-Quadrant Multiplication
- Improved ESD Resistance
- Packaged in a Narrow 0.3" 24-Pin DIP and 0.3" 24-Pin SOL package
- Available in Die Form


## APPLICATIONS

- Automatic Test Equipment
- Robotics/Process Control/Automation
- Digital Gain/Attenuation Control
- Ideal for Battery-Operated Equipment


## ORDERING INFORMATION ${ }^{\dagger}$

| relative ACCURACY ( +5 V or | GAIN ERROR 15V) | PACKAGE |  |  |
| :---: | :---: | :---: | :---: | :---: |
|  |  | MILITARY* TEMPERATURE $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | INDUSTRIAL TEMPERATURE $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | COMMERCIAL TEMPERATURE $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ |
| $\pm 1 / 2$ LSB | $\pm 1$ LSB | DAC8222AW | DAC8222EW | - |
| $\pm 1 / 2$ LSB | $\pm 2$ LSB | - | - | DAC8222GP |
| $\pm 1$ LSB | $\pm 4$ LSB | - | DAC8222FW | DAC8222HP |
| $\pm 1$ LSB | $\pm 4$ LSB | - | DAC8222FP | DAC8222HSH |

* For devices processed in total compliance to MIL-SDT-883, add /883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in cerdip, plastic dip, and TO-can packages.
tt For availability and burn-in information on SO and PLCC packages, contact your local sales office.


## GENERAL DESCRIPTION

The DAC-8222 is a dual 12-bit, double-buffered, CMOS digital-to-analog converter. It has a 12-bit wide data port that allows a 12-bit word to be loaded directly. This achieves faster throughput time in stand-alone systems or when interfacing to a 16-bit processor. A common 12-bit input TTL/CMOS compatible data port is used to load the 12-bit word into either of the two DACs. This port, whose data loading is similar to that of a RAM's write cycle, interfaces directly with most 12 -bit and 16 -bit bus systems. (See PMI's DAC-8248 for a complete 8-bit data bus interface product.) A common bus allows the DAC-8222 to be packaged in a narrow 24-pin 0.3" DIP and save PCB space.

PIN CONNECTIONS


28-CONTACT LCC
( TC-Suffix)


FUNCTIONAL DIAGRAM


This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

The DAC is controlled with two signals, $\overline{W R}$ and LDAC. With logic low at these inputs, the DAC registers become transparent. This allows direct unbuffered data to flow directly to either DAC output selected by DAC A/DAC B. Also, the DAC's doublebuffered digital inputs will allow both DACs to be updated simultaneously.
DAC-8222's monolithic construction offers excellent DAC-toDAC matching and tracking over the fulloperating temperature range. The chip consists of two thin-film R-2R resistor ladder networks, four 12-bit registers, and DAC control logic circuitry. The device has separate reference-input and feedback resistors for each DAC and operates on a single supply from +5 V to +15 V . Maximum power dissipation at +5 V using zero or $\mathrm{V}_{\mathrm{DD}}$ logic levels is less than 0.5 mW .
The DAC-8222 is manufactured with PMI's highly stable thinfilm resistors on an advanced oxide-isolated, silicon-gate, CMOS technology. PMI's improved latch-up resistant design eliminates the need for external protective Schottky diodes.

## ABSOLUTE MAXIMUM RATINGS

( $T_{A}=+25^{\circ} \mathrm{C}$, unless otherwise noted.)
$V^{\wedge}{ }^{A}$ to AGND
OV, +17V
$V_{D D}$ to DGND OV, +17V
AGND to DGND........................................ - $0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Digital Input Voltage to DGND ..................... $-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ $\mathrm{I}_{\text {OUT A }} \mathrm{I}_{\text {OUt }}$ to AGND ................................ $-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
$V_{\text {REF A }}, V_{\text {REF }}$ to AGND ,.............................................. $\pm 25 \mathrm{~V}$
$V_{\text {RFB A }}$, V $_{\text {RFB B }}$ to AGND ................................................... $\pm 25 \mathrm{~V}$
Operating Temperature Range

| AW Version ........................................... $-55^{\circ} \mathrm{C}$ to +125 ${ }^{\circ} \mathrm{C}$ |  |
| :---: | :---: |
|  |  |
| GP, HP, HS Versions ................................. - $0^{\circ} \mathrm{C}$ to + $70^{\circ} \mathrm{C}$ |  |
| Junction Temperature ............................................ $+150^{\circ} \mathrm{C}$ |  |
| Storage Temperature ................................. $-65^{\circ} \mathrm{C}$ to +150 |  |
| Lead Temperature (Soldering, 60 sec.) ..................... $+300^{\circ} \mathrm{C}$ |  |


| PACKAGE TYPE | $\theta_{\text {ja }}$ (NOTE 1) | $\theta_{\text {jc }}$ | UNITS |
| :---: | :---: | :---: | :---: |
| 24-Pin Hermetic DIP (W) | 69 | 10 | ${ }^{\circ} \mathrm{C}$ W |
| 24-Pin Plastic DIP (P) | 62 | 32 | ${ }^{\circ} \mathrm{CN}$ |
| 24-Pin SOL (S) | 72 | 24 | ${ }^{\circ} \mathrm{CNW}$ |

## NOTES:

1. $\Theta_{j A}$ is specified for worst case mounting conditions, i.e., $\Theta_{j A}$ is specified for device in socket for CerDIP, and P-DIP packages; $\Theta_{i A}$ is specified for device soldered to printed circuit board for SOL package.

## CAUTION:

1. Do no apply voltages higher than $V_{D D}$ or less than GND potential on any terminal except $V_{\text {REF }}$ and $R_{\text {FB }}$.
2. The digital control inputs are zener-protected; however, permanent damage may occur on unprotected units from high-energy electrostatic fields. Keep units in conductive foam at all times until ready to use.
3. Do not insert this device into powered sockets; remove power before insertion or removal.
4. Use proper anti-static handling procedures.
5. Devices can suffer permanent damage and/or reliability degradation if stressed above the limits listed under Absolute Maximum Ratings for extended periods.

ELECTRICAL CHARACTERISTICS at $V_{D D}=+5 \mathrm{~V}$ or $+15 \mathrm{~V}, \mathrm{~V}_{\text {REF } A}=V_{\text {REF }}=+10 \mathrm{~V}, V_{\text {OUT }}=V_{\text {OUT }}=0 \mathrm{~V}$; AGND = $D G N D=0 V$; $T_{A}=$ Full Temp Range Specified in Absolute Maximum Ratings; unless otherwise noted. Specifications apply for DAC $A$ and DAC $B$.

| PARAMETER | SYMBOL | CONDITIONS |  | MIN | $\begin{gathered} \text { DAC-8222 } \\ \text { TYP } \end{gathered}$ | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| STATIC ACCURACY |  |  |  |  |  |  |  |
| Resolution | $N$ | - $\cdot$ |  | 12 | - | - | Bits |
| Relative Accuracy | INL | Endpoint Linearity Error | DAC-8222A/E/G DAC-8222F/H | ; | - | $\begin{array}{r}  \pm 1 / 2 \\ \pm 1 \end{array}$ | LSB |
| Differential Nonlinearity | DNL | All Grades are Guarantee | otonic | - | - | $\pm 1$ | LSB |
| Full Scale Gain Error (Note 1) | $\mathrm{G}_{\text {FSE }}$ | $\begin{aligned} & \text { DAC-8222A/E } \\ & \text { DAC-8222G } \\ & \text { DAC-8222F/H } \end{aligned}$ |  | - | $-$ | $\begin{aligned} & \pm 1 \\ & \pm 2 \\ & \pm 4 \end{aligned}$ | LSB |
| Gain Temperature Coefficient $\Delta$ Gain/ $\Delta$ Temperature | TCG ${ }_{\text {FS }}$ | (Notes 2, 7) |  | - | $\pm 2$ | $\pm 5$ | ppm $/{ }^{\circ} \mathrm{C}$ |
| Output Leakage Current $I_{\text {OUt A ( }}$ (Pin 2), Iout B $^{\text {(Pin 24) }}$ | ILKG | All Digital Inputs $=$ 000000000000 | $\begin{aligned} & T_{A}=+25^{\circ} \mathrm{C} \\ & T_{A}=\text { Full Temp. Range } \end{aligned}$ | - | $\begin{gathered} \pm 5 \\ - \end{gathered}$ | $\begin{aligned} & \pm 10 \\ & \pm 50 \end{aligned}$ | nA |
| Input Resistance ( $\mathrm{V}_{\text {REF A }}, \mathrm{V}_{\text {REF }}$ ) | $\mathrm{R}_{\text {REF }}$ | (Note 9) | \% | 8 | 11 | 15 | k $\Omega$ |
| Input Resistance Match | $\frac{\Delta \mathrm{R}_{\mathrm{REF}}}{\mathbf{R}_{\mathrm{REF}}}$ |  | \% : : | - - | $\pm 0.2$ | $\pm 1$ | \% |
| DIGITAL ANPUTS |  |  |  |  |  |  |  |
| Digital Input High | $\mathrm{V}_{\text {INH }}$ | $\begin{aligned} & V_{D D}=+5 \mathrm{~V} \\ & V_{D D}=+15 \mathrm{~V} \end{aligned}$ |  | $\begin{array}{r} 2.4 \\ 13.5 \\ \hline \end{array}$ | - | - | V |
| Digital Input Low | $\mathrm{V}_{\text {INL }}$ | $\begin{aligned} & V_{D D}=+5 V \\ & V_{D D}=+15 V \end{aligned}$ |  | - | - | 0.8 1.5 | V |
| Input Current | IIN | $\begin{aligned} & V_{I N}=O V \text { or } V_{D D} \\ & \text { and } V_{I N L} \text { or } V_{I N H} \end{aligned}$ | $\begin{aligned} & T_{A}=+25^{\circ} \mathrm{C} \\ & T_{A}=\text { Full Temp. Range } \end{aligned}$ | - | $\pm 0.001$ | $\begin{array}{r}  \pm 1 \\ \pm 10 \\ \hline \end{array}$ | $\mu \mathrm{A}$ |
| Input Capacitance (Note 2) | $\mathrm{C}_{\text {IN }}$ | DB0-DB11 <br> $\overline{\text { WR }}, \overline{\text { LDAC }}, \overline{\mathrm{DAC} \mathrm{A}} \mathrm{DAC}$ |  | - | $-$ | 10 15 | pF |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V}$ or $+15 \mathrm{~V}, \mathrm{~V}_{\text {REFA }}=\mathrm{V}_{\text {REF } B}=+10 \mathrm{~V}, \mathrm{~V}_{\text {OUTA }}=\mathrm{V}_{\text {OUT } B}=0 \mathrm{~V}$; AGND $=\mathrm{DGND}=0 \mathrm{~V}$; $T_{A}=$ Full Temp Range specified in Absolute Maximum Ratings; unless otherwise noted. Specifications apply for DAC A and DAC B. Continued


## FEATURES

- Two 8-Bit Voltage Out DACs in a Single Chip
- Fits 7528/7628 Sockets
- Adjustment Free Internal CMOS Op Amps
- Single +12 V to +15 V Operation
- TTL Compatible Over Full $V_{D D}$ Range
- Fast Interface Timing $\qquad$ $T_{W R}=50 n s$
- Improved Resistance to ESD
- Available in Small Outline Package
- CerDIP and Epoxy Packages Come in the Extended Industrial Temperature Range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
- Available in Die Form


## APPLICATIONS

- Disk Drive Systems
- Automatic Test Equipment
- Process/Industrial Controls
- Energy Controls
- Programmable Instrumentation
- Multi-Channel Microprocessor-Controlled Systems
- Servo Control Systems

ORDERING INFORMATION ${ }^{\dagger}$

|  |  | PACKAGE: 20-PIN DIP/SOL |
| :---: | :---: | :---: |
|  |  | EXTENDED <br> RELATIVE |
| INDUSTRIAL |  |  |
| ACCURACY | GAIN | TEMPERATURE |
| $\pm 1 / 2$ LSB | $\pm 2 \mathrm{LSB}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| $\pm 1 / 2 \mathrm{LSB}$ | $\pm 2 \mathrm{LSB}$ | DAC8228FR |
| $\pm 1 / 2 \mathrm{LSB}$ | $\pm 2 \mathrm{LSB}$ | DAC8228FP |

$\dagger$ All commercial and industrial temperature range parts are available with burnin.

## GENERAL DESCRIPTION

The DAC-8228 is a dual 8-bit, voltage output, CMOS, D/A converter in a single chip. It was designed to drop into AD7528/7628 sockets eliminating two external op amps in applications such as hard disk drives. These applications generally operate the AD7528/7628 with zero volts applied to $\mathrm{V}_{\text {REF }}$ and offset AGND to +2.5 or +5 volts. The DAC-8228 is tested under both these conditions.
The DAC-8228 can also be used in those applications requiring a unipolar output voltage. It can deliver an output voltage between $O \mathrm{~V}$ and +10 V with $\mathrm{V}_{\mathrm{DD}}=+14 \mathrm{~V}$ (maximum output voltage is $\mathrm{V}_{\mathrm{DD}}-4 \mathrm{~V}$ ). The DAC-8228's reference input can accept a negative voltage from OV to-10V (the DAC's internal unity-gain inverting amplifier inverts the input signal). Choose the DAC8229 for bipolar operation.

Continued

## PIN CONNECTIONS

| N.C. 2 | 20 N.c. | 20-PIN 0.3" CERDIP |
| :---: | :---: | :---: |
| N.c. 2 | $10 \mathrm{~V}^{\text {out }}{ }^{\text {B }}$ |  |
| $V_{\text {OUt }}{ }^{3}$ | $18 \mathrm{~V}_{\text {feF }} \mathrm{B}$ | (R-Suffix) |
| $V_{\text {nes }}{ }^{\text {a }}$ | 17 vod |  |
| ¢no 5 | 16 WF | 20-PIN SOL |
| $\overline{\text { DACA/DAC }}$ - 6 | $1{ }^{\text {c }}$ cs | (S-Suffix) |
| (MS8) $\mathrm{DB}_{2} 7$ | 1980 ${ }^{\text {d }}$ |  |
| D88 8 | ${ }^{13} \mathrm{OB}$ | 20-PIN |
| $\mathrm{DB}_{5} 9$ | (12) $\mathrm{DB}_{2}$ | EPOXY DIP |
| OB4 4 | 111 $\mathrm{OB}_{3}$ | (P-Suffix) |



This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

## GENERAL DESCRIPTION Continued

The DAC-8228 offers CerDIP and plastic packaged devices in the extended industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. Applications requiring the military temperature range should use the DAC-8229. To make the DAC-8229 pin and functionally compatible with the DAC-8228, AGND A and AGND B should be tied together to function as $\mathrm{V}_{\mathbf{z}}$, and $\mathrm{V}_{\mathrm{ss}}$ connected to GND.
The DAC-8228 consists of two CMOS voltage output amplifiers, two high-accuracy R-2R resistor ladder networks, interface control logic, and two 8-bit registers. An internal regulator maintains TTL logic compatibility and fast microprocessor interface timing over the full $\mathrm{V}_{D D}$ range.
The DAC-8228 dissipates only 90 mW in the space saving 20pin 0.3" DIP or the 20 -lead SO surface mount package. Its compact size, low power, and economical cost per channel, makes it attractive for applications requiring multiple D/A converters without sacrificing circuit-board space. Reduced parts count also improves system reliability.
Using PMI's advanced oxide-isolated, silicon-gate CMOS process, coupled with its highly-stable thin-film resistor ladder, allows the DAC-8228 to offer superior matching and temperature tracking between DACs.

## ABSOLUTE MAXIMUM RATINGS

| ( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.) |  |  |  |
| :---: | :---: | :---: | :---: |
|  |  |  |  |
| Digital Input Voltage to GND |  |  |  |
| $V_{\text {REF A }}, V_{\text {REF }}$ to GND ......................................... -17V, $\mathrm{V}_{\mathbf{Z}}$ |  |  |  |
| $\mathrm{V}_{\text {OUT }}, \mathrm{V}_{\text {OUT }}$ to $\mathrm{V}_{\mathbf{Z}}$ (Note 1) ............................. -0.3V, $\mathrm{V}_{\text {DD }}$ |  |  |  |
| Operating Temperature Range |  |  |  |
| FR/FP/FS Versions ................................... $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  |  |
| Junction Temperature ............................................ +150 ${ }^{\circ} \mathrm{C}$ |  |  |  |
| Storage Temperature $\qquad$ $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ <br> Lead Temperature (Soldering, 60 sec ) $\qquad$ $+300^{\circ} \mathrm{C}$ |  |  |  |
|  |  |  |  |
| PACKAGE TYPE | $\Theta_{\text {IA }}$ (NOTE 3) | $\theta_{1 c}$ | UNITS |
| 20-Pin Hermetic DIP (R) | 76 | 11 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 20-Pin Plastic DIP (P) | 69 | 27 | ${ }^{\circ} \mathrm{CN}$ |
| 20-Pin SOL (S) | 88 | 25 | ${ }^{\circ} \mathrm{C}$ |

NOTES:

1. Outputs may be shorted to any terminal provided the package power dissipation is not exceeded. Typical output short-circuit current to GND is 50 mA .
2. Use proper anti-static handling procedures when handling these devices.
3. $\boldsymbol{\theta}_{j A}$ is specified for worst case mounting conditions, i.e., $\boldsymbol{\theta}_{j A}$ is specified for device in socket for CerDIP and P-DIP packages; $\boldsymbol{\theta}_{\mathrm{jA}}$ is specified for device soldered to printed circuit board for SOL package.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{DD}}=+12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{REF}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{Z}}=+2.5 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{DD}}=+15 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{REF}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{Z}}=+5 \mathrm{~V}$.
$T_{A}=$ Full Temperature Range specified under Absolute Maximum Ratings, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | MIN | $\begin{gathered} \text { DAC-8228 } \\ \text { TYP } \end{gathered}$ | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| STATIC ACCURACY (Note 1) |  |  |  |  |  |  |
| Resolution | $N$ |  | 8 | - | - | Bits |
| Relative Accuracy (Note 2) | INL |  | - | - | $\pm 1$ | LSB |
| Differential Nonlinearity (Note 3) | DNL |  | - | - | $\pm 1$ | LSB |
| Gain Error | $\mathrm{G}_{\text {FSE }}$ | DAC Latches Loaded with 11111111 | - | - | $\pm 2$ | LSB |
| Gain Error Temperature Coefficient (Note 4) | TCG ${ }_{\text {FS }}$ |  | - | $\pm 0.0003$ | $\pm 0.002$ | \%/ ${ }^{\circ} \mathrm{C}$ |
| Zero Code Error | $V_{\text {zSE }}$ |  | - | - | $\pm 15$ | mV |
| Zero Code Error <br> Temperature Coefficient (Note 4) | $\mathrm{TCV}_{2 s}$ |  | - | $\pm 10$ | - | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| REFERENCE INPUT (Note 8) |  |  |  |  |  |  |
| Input Resistance (Note 5) | $\mathrm{R}_{\text {IN }}$ | Pin 4 and Pin 18 | 7 | - | 15 | $k \Omega$ |
| Input Resistance Match $\left(N_{\text {REF }} A N_{\text {REF }} B\right)$ | $\frac{\Delta R_{I N}}{R_{I N}}$ |  | - | $\pm 0.1$ | $\pm 1$ | \% |
| Input Capacitance (Note 4) | $C_{1 N}$ |  | - | 9 | 20 | pF |
| $\mathrm{V}_{\mathbf{z}}$ Input Resistance <br> (Note 10) | $\mathbf{R}_{\mathbf{v z}}$ | Digital Inputs = OV | 2 | - | - | k |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{DD}}=+12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\text {REF }}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{Z}}=+2.5 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{DD}}=+15 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\text {REF }}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{Z}}=+5 \mathrm{~V}$.
$T_{A}=$ Full Temperature Range specified under Absolute Maximum Ratings, unless otherwise noted. Continued


ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{DD}}=+12 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\text {REF }}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{Z}}=+2.5 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{DD}}=+15 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\text {REF }}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{Z}}=+5 \mathrm{~V}$. $T_{A}=$ Full Temperature Range specified under Absolute Maximum Ratings, unless otherwise noted. Continued

| PARAMETER | SYMBOL | CONDITIONS | MIN | $\begin{gathered} \text { DAC-8228 } \\ \text { TYP } \end{gathered}$ | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SWITCHING CHARACTERISTICS (Note 4) |  |  |  |  |  |  |
| Chip Select to Write Set-Up Time | ${ }^{t} \mathrm{CS}$ |  | 60 | - | - | ns |
| Chip Select to Write Hold Time | ${ }^{t} \mathrm{CH}$ |  | 10 | - | - | ns |
| DAC Select to Write Set-Up Time | $t_{\text {AS }}$ |  | 60 | - | - | ns |
| DAC Select to Write Hold Time | $t_{\text {AH }}$ |  | 10 | - | - | ns |
| Data Valid to Write Set-Up Time | $\mathrm{t}_{\mathrm{DS}}$ |  | 60 | - | - | ns |
| Data Valid to Write Hold Time | ${ }^{\text {t }}$ D |  | 10 | - | - | ns |
| Write Pulse Width | $t_{\text {w }}$ | $\cdots$ | 50 | - | - | ns |

## NOTES:

1. Specifications apply to both DAC $A$ and DAC B.
. This is an endpoint linearity specification.
2. All devices are guaranteed to be monotonic over the full operating temperature range.
3. These characteristics are for design guidance only and not subject to production test.
4. Input resistance temperature coefficient $=+300 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$.
5. $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{INL}}$ or $\mathrm{V}_{\mathrm{INH}}$; outputs unloaded.
6. $V_{\text {REF }}= \pm 2.5 \mathrm{~V}$; to where output settles to $\pm 1 / 2$ LSB.
7. $\mathrm{V}_{\mathrm{REF}}$ voltage range is 0 V to -10 V ; the absolute maximum negative value is: $\left|V_{\text {REF }}\right|=V_{D D}-4 V$.
8. Digital crosstalk is a measure of the amount of digital input pulse appearing at the analog output of the unselected DAC while applying it to the digital inputs of the other DAC.
9. Resistance looking into the $V_{Z}$ terminal.
10. $V_{R E F} A, V_{R E F} B=20 V_{p-p}$ Sinewave $@ f=10 \mathrm{kHz} ; V_{R E F} A$ to $V_{O U T} A$ or $V_{R E F} B$ to $V_{\text {OUT }} B$, both DAC latches loaded with 00000000.

## BURN-IN CIRCUIT




ANALOG

## FEATURES

- Two 8-Bit DACs In A Single Chip
- Adjustment-Free Internal CMOS Amplifiers
- Single or Dual Supply Operation
- TTL Compatible Over Full $V_{D D}$ Range
- 5 Microsecond Settling Time
- Fast Interface Timing $\qquad$ $t_{w R}=50 n s$
- Improved Resistance to ESD
- Fits AD/PM-7528 And AD/PM-7628 Sockets
- Available In Small Outline Package
- $-\mathbf{4 0 ^ { \circ }} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ for the Extended Industrial Temperature Range
- Available In Die Form


## APPLICATIONS

- Automatic Test Equipment
- Process/Industrial Controls
- Energy Controls
- Programmable Instrumentation
- Disk Drive Systems
- Multi-Channel Microprocessor-Controlled Systems


## GENERAL DESCRIPTION

The DAC-8229 is a dual 8-bit, voltage output, multiplying CMOS $D / A$ converter. Its reference input accepts a $\pm 2.5 \mathrm{~V}$ signal, inverts and delivers it to the output with an internal amplifier. It can also accept -10 V at $\mathrm{V}_{\text {REF }}$ with a corresponding +10 V output (the maximum positive input signal that it can accept is +2.5 V ).
The DAC-8229 was designed to operate with dual supplies; however, it can be operated with a single supply by connecting

ORDERING INFORMATION ${ }^{\dagger}$

| RELATIVE ACCURACY | PACKAGE: 20-PIN DIP/SOL |  |  |
| :---: | :---: | :---: | :---: |
|  | $\begin{aligned} & \text { GAIN } \\ & \text { ERROR } \end{aligned}$ | MILTARY* <br> TEMPERATURE $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | EXTENDED" ${ }^{\#}$ industrial TEMPERATURE $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| $\pm 1 / 2 \mathrm{LSB}$ | $\pm 2 \mathrm{LSB}$ | DAC8229AR | DAC8229ER |
| $\pm 1 / 2 \mathrm{LSB}$ | $\pm 2 \mathrm{LSB}$ | - | DAC8229FP |
| $\pm 1 / 2$ LSB | $\pm$ 2LSB | - | DAC8229FS |

* For devices processed in total compliance to MIL-STD-883, add /883 after part number. Consult factory for $\mathbf{8 8 3}$ data sheet.
$\dagger$ All commercial and industrial temperature range parts are available with burnin.
t Cerdip and epoxy packaged devices available in the extended industrial temperature range.


## PIN CONNECTIONS




This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{DD}}=+11.4 \mathrm{~V}$ or $+15.75 \mathrm{~V} ; \mathrm{V}_{\mathrm{SS}}=-5 \mathrm{~V} \pm 10 \% ; \mathrm{V}_{\mathrm{REF}}= \pm 2.5 \mathrm{~V} ; \mathrm{AGND}=0 \mathrm{~V} ; \mathrm{T}_{\mathrm{A}}=$ Full Temperature Range specified under Absolute Maximum Ratings, unless otherwise noted. Continued

| PARAMETER | SYMBOL | CONDITIONS | MIN | $\begin{gathered} \text { DAC-8229 } \\ \text { TYP } \end{gathered}$ | max | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DIGITAL INPUTS |  |  |  |  |  |  |
| Digital Input High | $\mathrm{V}_{\text {INH }}$ |  | 2.4 | - | - | v |
| Digital Input Low | $V_{\text {INL }}$ |  | - | - | 0.8 | V |
| Input Current | In | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{DD}}$ | - | - | $\pm 1$ | $\mu \mathrm{A}$ |
| Input Capacitance (Note 4) | $\mathrm{C}_{\text {IN }}$ |  | - | 4 | 8 | pF |
| POWER SUPPLIES |  |  |  |  |  |  |
| Positive Supply Current (Note 6) | ID |  | - | - | 6 | mA |
| Negative Supply Current (Note 6) | $\mathrm{Iss}^{\text {s }}$ |  | - | - | 5 | mA |
| DC Power Supply <br> Rejection Ratio <br> $\left(\Delta\right.$ Gain $\left./ \Delta V_{D D}\right)($ Note 10 $)$ $\Delta V_{D D}= \pm 5 \%$ - PSRR |  |  |  |  |  |  |
| DYNAMIC PERFORMANCE |  |  |  |  |  |  |
| $\begin{aligned} & \text { Slew Rate }\left(V_{\text {OUT }}\right) \\ & \text { (Note 4) } \end{aligned}$ | SR | $\begin{aligned} & T_{A}=25^{\circ} \mathrm{C} \\ & V_{\mathrm{REF}}=-2.5 \mathrm{~V} \\ & \text { Digital Inputs }=0 \mathrm{~V} \text { to }+5 \mathrm{~V} \end{aligned}$ | - | 2.5 | - | V/us |
| Setting Time $\left(N_{\text {OUT }}\right)$ Positive or Negative (Notes 4,7) | $\mathrm{t}_{s}$ | $\begin{aligned} & V_{\text {REF }}=-2.5 \mathrm{~V} \\ & \text { Digita Inputs }=0 \mathrm{~V} \text { to }+5 \mathrm{~V} \end{aligned}$ | - | 2 | 5 | us |
| Channel-to-Channel Isolation (Note 4) | CCI | $\mathrm{V}_{\text {REF }} \mathrm{B}$ to $\mathrm{V}_{\text {OUT }} \mathrm{A}$ or $\mathrm{V}_{\text {REF }}$ $V_{R E F} B=V_{R E F} A=20 V_{p-p}$ | - | -80 | - | dB |
| Digital Crosstalk (Notes 4, 9) | 0 | For Code Transition 00000000 to 11111111 | - | 4 | 10 | nVs |
| AC Feedthrough (Notes 4, 11) | $\mathrm{F}_{\mathrm{T}}$ | $\begin{aligned} & T_{A}=25^{\circ} \mathrm{C} \\ & T_{A}=\text { Full Temp. Range } \end{aligned}$ | - | - | $\begin{aligned} & -70 \\ & -65 \end{aligned}$ | dB |
| SWITCHING CHARACTERISTICS (Note 4) |  |  |  |  |  |  |
| Chip Select to Write Set-Up Time | $\mathrm{t}_{\mathrm{cs}}$ |  | 60 | - | - | ns |
| Chip Select to Write Hold Time | ${ }^{\text {cher }}$ |  | 10 | - | - | ns |
| DAC Select to Write Set-Up Time | $t_{\text {AS }}$ |  | 60 | - | - | ns |
| DAC Select to Write Hold Time | ${ }^{\text {AH }}$ |  | 10 | - | - | ns |
| Data Valid to Write Set-Up Time | tos |  | 60 | - | - | ns |
| Data Valid to Write Hold Time | ${ }_{\text {b }}{ }^{\text {H }}$ |  | 10 | - | - | ns |
| Write Pulse Width | $t^{\text {w }}$ |  | 50 | - | - | ns |
| NOTES: <br> 1. Specifications apply to both DAC A and DAC B. <br> 2. This is an endpoint linearity specification. <br> 3. All devices are guaranteed to be monotonic over the full operating temperature range. <br> 4. These characteristics are for design guidance only and are not subject to production test. <br> 5. Input resistance temperature coefficient $=+300 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$. <br> 6. $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{INL}}$ or $\mathrm{V}_{\mathrm{INH}}$; outputs unloaded. <br> 7. $V_{\text {REF }}= \pm 2.5 \mathrm{~V}$; to where output settles to $\pm 1 / 2$ LSB. |  |  | 8. $\mathrm{V}_{\text {REF }}$ voltage range is +3 V to -10 V ; the absolute maximum negative value is: $\left\|V_{R E F}\right\|=V_{D D}-4 V .$ <br> 9. Digital crosstalk is a measure of the amount of digital input pulse appearing at the analog output of the unselected DAC while applying it to the digital inputs of the other DAC. <br> 10. $\mathrm{V}_{\text {REF }}=+2.5 \mathrm{~V}, \mathrm{R}_{\text {PULLDOWN }}=20 \mathrm{k} \Omega$ (a pulldown resistor to $\mathrm{V}_{\text {SS }}$ is used for these tests). <br> 11. $V_{R E F} A, V_{\text {REF }} B=20 V_{p-p}$ Sinewave @ $f=10 \mathrm{kHz}$; $V_{R E F} A$ to $V_{\text {REF }} B$ or $V_{R E F}^{\rho-p} B$ to $V_{\text {REF }} A$. |  |  |  |

## GENERAL DESCRIPTION Continued

$\mathrm{V}_{\text {Ss }}$ AGND A, and AGND B to ground. Its operating characteristics will then be similar to that of the DAC-8228 (whose pin-out allows it to drop into the AD/PM-7528 and AD/PM-7628 sockets).
An internal regulator provides TTL logic compatibility and fast microprocessor interface timing over the full $\mathrm{V}_{\mathrm{DD}}$ range. Also, each DAC input latch is addressable for easy microprocessor interfacing.

The DAC-8229 dissipates less than 109 mW in the space-saving 20-pin 0.3" DIP or the 20 -lead SO surface-mount package. Its compact size, low power, and economical cost per channel, make it attractive for applications requiring multiple $\mathrm{D} / \mathrm{A}$ converters without sacrificing circuit-board space. Reduced parts count also improves system reliability.
PMI's advanced oxide-isolated, silicon-gate CMOS process, coupled with PMI's highly-stable thin-film R-2R resistor ladder, offers superior matching and temperature tracking between DACs.

The DAC-8229 offers cerdip or epoxy packaged devices in the extended industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.

ABSOLUTE MAXIMUM RATINGS $\left(\mathrm{T}_{\mathrm{A}}=\mathbf{+ 2 5 ^ { \circ }} \mathbf{C}\right.$, uniess oth erwise noted.)

| $V_{\text {ss }}$ to AGND or |  |  | +17 |
| :---: | :---: | :---: | :---: |
| $V_{\text {DD }}$ to $\mathrm{V}_{\text {SS }} \ldots \ldots . .$. |  |  | +24V |
| AGND to DGND |  |  | - |
| Digital Input Voltage |  |  | V, $\mathrm{V}_{\mathrm{DD}}$ |
| $V_{\text {REF }}$ to AGND . |  |  | V, +4V |
| $V_{\text {OUT }}$ to AGND (No | ... |  | S, $\mathrm{V}_{\mathrm{DD}}$ |
| Operating Tempera |  |  |  |
| DAC-8229AR Ve |  |  | $+125^{\circ} \mathrm{C}$ |
| DAC-8229ER/FP | sions |  | $+85^{\circ} \mathrm{C}$ |
| Junction Temperatu |  |  | $+150^{\circ} \mathrm{C}$ |
| Storage Temperatu |  | -6 | $+150^{\circ} \mathrm{C}$ |
| Lead Temperature | in, 60 sec ) |  | $+300^{\circ} \mathrm{C}$ |
| PACKAGE TYPE | $\boldsymbol{\theta}_{\text {IA }}$ (NOTE 3) | $\theta_{\text {Ic }}$ | UNITS |
| 20-Pin Hermetic DIP (R) | 76 | 11 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 20-Pin Plastic DIP (P) | 69 | 27 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 20-Pin SOL (S) | 88 | 25 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTES:

1. Outputs may be shorted to any terminal provided the package power dissipation is not exceeded. Typical output short-circuit current to AGND is 50 mA
2. Use proper antistatic handling procedures when handling these devices.
3. $\Theta_{j A}$ is specified for worst case mounting conditions, i.e., $\Theta_{j A}$ is specified for device in socket for CerDIP and P-DIP packages; $\Theta_{\mathrm{jA}}$ is specified for device soldered to printed circuit board for SOL package.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{DD}}=+11.4 \mathrm{~V}$ or $+15.75 \mathrm{~V} ; \mathrm{V}_{\mathrm{SS}}=-5 \mathrm{~V} \pm 10 \% ; \mathrm{V}_{\mathrm{REF}}= \pm 2.5 \mathrm{~V} ; \mathrm{AGND}=0 \mathrm{~V} ; \mathrm{T}_{\mathrm{A}}=$ Full Temperature Range specified under Absolute Maximum Ratings, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | MIN | $\begin{gathered} \text { DAC-8 } \\ \text { TYP } \end{gathered}$ | MAX | UNTTS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| STATIC ACCURACY (Note 1) |  |  |  |  |  |  |
| Resolution | $N$ |  | 8 | - | - | Bits |
| Relative Accuracy (Note 2,10) | INL |  | - | - | $\pm 1 / 2$ | LSB |
| Differential Nonlinearity (Note 3, 10) | DNL |  | - | - | $\pm 1$ | LSB |
| Gain Error (Note 10) | $\mathrm{G}_{\text {FSE }}$ |  | - | - | $\pm 2$ | LSB |
| Gain Error <br> Temperature Coefficient (Note 4, 10) | TCG ${ }_{\text {FS }}$ |  | - | $\pm 0.0008$ | $\pm 0.002$ | \%/C |
| Zero Gain Error (Note 10) | $\mathrm{V}_{\text {zSE }}$ |  | - | - | $\pm 10$ | mV |
| Zero Code Error <br> Temperature Coefficient (Note 4, 10) | $\mathrm{TCV}_{\mathbf{z s}}$ |  | - | $\pm 5$ | - | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| REFERENCE INPUT <br> (Note 8) |  |  |  |  |  |  |
| Input Resistance (Note 5) | $\mathrm{R}_{\mathbf{I N}}$ |  | 7 | - | 15 | 168 |
| Input Resistance Match $\left.N_{\text {REF }} A N_{\text {REF }}{ }^{B}\right)$ | $\begin{aligned} & \Delta \mathbf{R}_{\mathrm{IN}} \\ & \mathbf{R}_{\mathrm{IN}} \end{aligned}$ |  | - | $\pm 0.1$ | $\pm 1$ | \% |
| Input Capacitance (Note 4) | $\mathrm{C}_{\text {IN }}$ |  | - | 9 | 20 | pF |

## DAC8248

## FEATURES

- Two Matched 12-Bit DACs on One Chip
- 12-Bit Resolution with an 8-Bit Data Bus
- Direct Interface with 8-Bit Microprocessors
- Double-Buffered Digital Inputs
- $\overline{\text { RESET }}$ to Zero Pin
- 12-Bit Endpont Linearity ( $\pm 1 / 2$ LSB) Over Temperature
- +5 V to +15 V Single Supply Operation
- Latch-Up Resistant
- Improved ESD Resistance
- Packaged in a Narrow 0.3" 24-Pin DIP and 0.3" 24-Pin SOL package
- Available in Die Form


## APPLICATIONS

- Multi-Channel Microprocessor-Controlled Systems
- Robotics/Process Control/Automation
- Automatic Test Equipment
- Programmable Attenuator, Power Supplies, Window Comparators
- Instrumentation Equipment
- Battery Operated Equipment


## GENERAL DESCRIPTION

The DAC-8248 is a dual 12-bit, double-buffered, CMOS digital-to-analog converter. It has an 8 -bit wide input data port that
interfaces directly with 8-bit microprocessors. It loads a 12-bit word in two bytes using a single control; it can accept either a least significant byte or most significant byte first. For designs with a 12-bit or 16-bit wide data path, choose the DAC-8222 or DAC-8221.

The DAC-8248's double-buffered digital inputs allow both DAC's analog output to be updated simultaneously. This is particularly useful in multiple DAC systems where a common $\overline{\text { LDAC }}$ signal updates all DACs at the same time. A single $\overline{R E S E T}$ pin resets both outputs to zero.

## ORDERING INFORMATION $\dagger$

| RELATIVE GAINACCURACY ERROR( +5 V or +15 V ) |  | PACKAGE |  |  |
| :---: | :---: | :---: | :---: | :---: |
|  |  | MILITARY* TEMPERATURE $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | INDUSTRIAL TEMPERATURE $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | COMMERCIAL TEMPERATURE $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ |
| $\pm 1 / 2$ LSB | $\pm 1$ LSB | DAC8248AW | DAC8248EW | - |
| $\pm 1 / 2$ LSB | $\pm 2$ LSB | - | - | DAC8248GP |
| $\pm 1$ LSB | $\pm 4$ LSB | - | DAC8248FW | DAC8248HP |
| $\pm 1$ LSB | $\pm 4$ LSB | - | DAC8248FP | DAC8248HS $\dagger \dagger$ |

* For devices processed in total compliance to MIL-STD-883, add/883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.
t1 For availability and burn-in information on SO and PLCC packages, contact your local sales office.


## FUNCTIONAL DIAGRAM

## DAC8248

The DAC-8248's monolithic construction offers excellent DAC-to-DAC matching and tracking over the full operating temperature range. The DAC consists of two thin-film R-2R resistor ladder networks, two 12-bit, two 8-bit, and two 4-bit data registers, and control logic circuitry. Separate reference input and feedback resistors are provided for each DAC. The DAC8248 operates on a single supply from +5 V to +15 V , and it dissipates less than 0.5 mW at +5 V (using zero or $\mathrm{V}_{\mathrm{DD}}$ logic levels). The device is packaged in a space-saving $0.3^{\prime \prime}, 24$-pin DIP.

The DAC-8248 is manufactured with PMI's highly-stable thinfilm resistors on an advanced oxide-isolated, silicon-gate, CMOS technology. PMI's improved latch-up resistant design eliminates the need for external protective Schottky diodes.

## PIN CONNECTIONS



ABSOLUTE MAXIMUM RATINGS

| $=+25^{\circ} \mathrm{C}$, unless otherwise noted.) |  |  |  |
| :---: | :---: | :---: | :---: |
|  |  |  |  |
| AGND to DGND....................................... $-0.3 \mathrm{~V}, \mathrm{~V}_{\text {DD }}+0.3 \mathrm{~V}$ |  |  |  |
| Digital Input Voltage to DGND ................... $-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |  |  |  |
| Iout A. $\mathrm{I}_{\text {OUt }}$ to AGND ................................. -0.3V, $\mathrm{V}_{\text {DD }}+0.3 \mathrm{~V}$ |  |  |  |
|  |  |  |  |
| $V_{\text {RFB A }}, V_{\text {RFB B }}$ to AGND $\qquad$ $\pm 25 \mathrm{~V}$ <br> Operating Temperature Range |  |  |  |
|  |  |  |  |
| AW Version .......................................... $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  |  |  |
| EW, FW, FP Versions............................... $-40^{\circ} \mathrm{C}$ to +85 |  |  |  |
| GP, HP, HS Versions ................................. - $0^{\circ} \mathrm{C}$ to + $70^{\circ} \mathrm{C}$ |  |  |  |
| Junction Temperature ............................................... +150C |  |  |  |
| Storage Temperature ................................. -65 ${ }^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |  |  |  |
| Lead Temperature (Soldering, 60 sec ) ....................... +300 ${ }^{\circ} \mathrm{C}$ |  |  |  |
| PACKAGE TYPE | $\Theta_{\text {1a }}$ (Note 1) | $\theta_{\text {Ic }}$ | UNITS |
| 24-Pin Hermetic DIP (W) | 69 | 10 | ${ }^{\circ} \mathrm{CN}$ |
| 24-Pin Plastic DIP (P) | 62 | 32 | ${ }^{\circ} \mathrm{CNW}$ |
| 24-Pin SOL (S) | 72 | 24 | ${ }^{\circ} \mathrm{CW}$ |

NOTE:

1. $\Theta_{j A}$ is specified for worst case mounting conditions, i.e., $\Theta_{j A}$ is specified for device in socket for CerDIP and P-DIP packages; $\Theta_{j A}$ is specified for device soldered to printed circuit board for SOL package.
CAUTION:
2. Do no apply voltages higher than $\mathrm{V}_{D D}$ or less than GND potential on any terminal except $V_{\text {REF }}$ and R $_{\text {FB }}$.
3. The digital control inputs are zener-protected; however, permanent damage may occur on unprotected units from high-energy electrostatic fields. Keep units in conductive foam at all times until ready to use.
4. Do not insert this device into powered sockets; remove power before insertion or removal.
5. Use proper anti-static handling procedures.
6. Devices can suffer permanent damage and/or reliability degradation if stressed above the limits listed under Absolute Maximum Ratings for extended periods. This is a stress rating only and functional operation at or above this specification is not implied.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V}$ or $+15 \mathrm{~V} ; \mathrm{V}_{\text {REF } A}=\mathrm{V}_{\text {REF } B}=+10 \mathrm{~V} ; \mathrm{V}_{\text {OUT }}=\mathrm{V}_{\text {OUT }} \mathrm{B}=0 \mathrm{~V} ; \mathrm{AGND}=\mathrm{DGND}=0 \mathrm{~V}$; $T_{A}=$ Full Temp Range specified in Absolute Maximum Ratings; unless otherwise noted. Specifications apply for DAC A and DAC B.

| PARAMETER | SYMBOL | CONDITIONS | MIN | $\begin{gathered} \text { DAC-8248 } \\ \text { TYP } \end{gathered}$ | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| STATIC ACCURACY |  |  |  |  |  |  |
| Resolution | N |  | 12 | - | - | Bits |
| Relative Accuracy | INL | DAC-8248A/E/G DAC-8248F/H | - | $-$ | $\begin{array}{r}  \pm 1 / 2 \\ \pm 1 \end{array}$ | LSB |
| Differential Nonlinearity | DNL | All Grades are Guaranteed Monotonic | - | - | $\pm 1$ | LSB |
| Full Scale Gain Error (Note 1) | $\mathrm{G}_{\text {FSE }}$ | DAC-8248A/E DAC-8248G DAC-8248F/H | - | - | $\pm 1$ $\pm 2$ $\pm 4$ | LSB |
| Gain Temperature Coefficient ( $\Delta$ Gain/ $\Delta$ Temperature) | $\mathrm{TCG}_{\text {FS }}$ | (Notes 2, 6) | - | $\pm 2$ | $\pm 5$ | ppm $/{ }^{\circ} \mathrm{C}$ |

ELECTRICAL CHARACTERISTICS at $V_{D D}=+5 \mathrm{~V}$ or $+15 \mathrm{~V} ; \mathrm{V}_{\text {REF } A}=\mathrm{V}_{\text {REF }}=+10 \mathrm{~V} ; \mathrm{V}_{\text {OUT }}=V_{\text {OUT }}=0 \mathrm{~V} ; A G N D=D G N D=0 \mathrm{~V}$; $T_{A}=$ Full Temp Range specified in Absolute Maximum Ratings; unless otherwise noted. Specifications apply for DAC A and DAC B. (Continued)

| PARAMETER |  |  | CONDITIONS |
| :--- | :--- | :--- | :--- |

## DAC8428

ELECTRICAL CHARACTERISTICS at $V_{D D}=+5 \mathrm{~V}$ or $+15 \mathrm{~V}, \mathrm{~V}_{\text {REFA }}=\mathrm{V}_{\text {REF } B}=+10 \mathrm{~V} ; \mathrm{V}_{\text {OUTA }}=V_{\text {OUT } B}=0 \mathrm{~V}$; AGND $=\mathrm{DGND}=0 \mathrm{~V}$; $T_{A}=$ Full Temp Range specified in Absolute Maximum Ratings; unless otherwise noted. Specifications apply for DAC A and DAC B. Continued


## BURN-IN CIRCUIT



Quad 8-Bit Multiplying CMOS D/A Converter with Memory

## FEATURES

- Four DACs in a 28 Pin, 0.6 Inch Wide DIP or 28 Pin JEDEC Plastic Chip Carrier
- $\pm 1 / 4$ LSB End-Point Linearity
- Guaranteed Monotonic
- DACs Matched to Within 1\%
- Microprocessor Compatible
- Read/Write Capability (with Memory)
- TTL/CMOS Compatible
- Four-Quadrant Multiplication
- Single-Supply Operation (+5V)
- Low Power Consumption
- Latch-Up Resistant
- Avallable in Dle Form


## APPLICATIONS

- Voltage Set Points in Automatic Test Equipment
- Systems Requiring Data Access for Self-Diagnostics
- Industrial Automation
- Multi-Channel Microprocessor-Controlled Systems
- Digitally Controlled Op Amp Offset Adjustment
- Process Control
- Digital Attenuators


## GENERAL DESCRIPTION

The DAC-8408 is a monolithic quad 8-bit multiplying digital-toanalog CMOS converter. Each DAC has its own reference input, feedback resistor, and on-board data latches that feature read/write capability. The readback function serves as memory for those systems requiring self-diagnostics.

A common 8-bit TTL/CMOS compatible input port is used to load data into any of the four DAC data-latches. Control lines $\overline{\mathrm{DS} 1}, \overline{\mathrm{DS} 2}$, and A/B determine which DAC will accept data. Data loading is similar to that of a RAM's write cycle. Data can be read back onto the same data bus with control line $R / \bar{W}$. The DAC-8408 is bus compatible with most 8-bit microprocessors, including the 6800, 8080, 8085, and Z80. The DAC-8408 operates on a single +5 volt supply and dissipates less than 20 mW . The DAC-8408 is manufactured using PMI's highly stable, thin-film resistors on an advanced oxide-isolated, silicon-gate, CMOS process. PMI's improved latch-up resistant design eliminates the need for external protective Schottky diodes.

ORDERING INFORMATION ${ }^{\dagger}$

| INL | DNL | PACKAGE |  |  |
| :---: | :---: | :---: | :---: | :---: |
|  |  | COMMERCIAL TEMPERATURE $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | EXTENDED INDUSTRIAL TEMPERATURE $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | MILITARY* TEMPERATURE $-55^{\circ} \mathrm{C}$ to $\mathbf{~}^{125}{ }^{\circ} \mathrm{C}$ |
| $\pm 1 / 4 \mathrm{LSB}$ | $\pm 1 / 2 L S B$ | DAC8408GP | DAC8408ET | DAC8408AT |
| $\pm 1 / 2 \mathrm{LSB}$ | $\pm 1$ LSB | - | DAC8408FT | DAC8408BT |
| $\pm 1 / 2$ LSB | $\pm 1$ LSB | - | DAC8408FPC ${ }^{\dagger \dagger}$ | - |
| $\pm 1 / 2 \mathrm{LSB}$ | $\pm 1$ LSB | - | DAC8408FS | - - |
| $\pm 1 / 2$ LSB | $\pm 1$ LSB | - | DAC8408FP | - |

- For devices processed in total compliance to MIL-STD-883, add /883 after part number. Consult factory for 883 data sheet.
t Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.
H For availability and burn-in information on SO and PLCC packages, contact your local sales office.


## FUNCTIONAL DIAGRAM



This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.


ABSOLUTE MAXIMUM RATINGS $\left(T_{A}=+25^{\circ} \mathrm{C}\right.$, unless otherwise noted.)

$V_{D D}$ to DGND ........................................................... 0, $\mathbf{+ 7 V}$
IOUT 1A, IOUT 18'
Iout 1 c, lout 10 to DGND
-0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$

Iout 2A. IOUT 2B'
$\mathrm{I}_{\text {OUT } 2 \mathrm{C}}, \mathrm{I}_{\text {OUT } 2 \mathrm{D}}$ to DGND ...................... -0.3 V to $\mathrm{V}_{\text {DD }}+0.3 \mathrm{~V}$
DB0 through DB7 to DGND....................... -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Control Logic Input Voltage to DGND $\qquad$ $-0.3 \mathrm{~V}+\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
$\mathbf{V}_{\text {REF }} A, V_{\text {REF }} B, V_{\text {REF }} C, V_{\text {REF }} D$ to

Operating Temperature Range
Commercial Grade (GP) $\qquad$ $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Industrial Grade (ET, FT, FP, FPC, FS) ...... $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Military Grade (AT, BT) ............................ $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Junction Temperature $\qquad$ $+150^{\circ} \mathrm{C}$

Storage Temperature .................................. $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 sec ) ....................... $+300^{\circ} \mathrm{C}$

| PACKAGE TYPE | $\Theta_{\text {jA }}($ Note 1) | $\theta_{\text {Jc }}$ | UNITS |
| :--- | :---: | :---: | :---: |
| 28-Pin Hermetic DIP (I) | 55 | 10 | ${ }^{\circ} \mathrm{CWW}$ |
| 28-Pin Plastic DIP (P) | 53 | 27 | ${ }^{\circ} \mathrm{CWW}$ |
| 28-Pin SOL (S) | 68 | 23 | ${ }^{\circ} \mathrm{CWW}$ |
| 28-Contact PLCC (PC) | 66 | 29 | ${ }^{\circ} \mathrm{CW}$ |

## NOTE:

1. $\Theta_{j A}$ is specified for worst case mounting conditions, i.e., $\Theta_{j A}$ is specified for dévice in socket for CerDIP and P-DIP packages; $\Theta_{j A}$ is specified for device soldered to printed circuit board for SOL and PLCC packages.

## CAUTION:

1. Do not apply voltages higher than $V_{D D}+0.3 \mathrm{~V}$ or less than -0.3 V potential on any terminal except $V_{\text {REF }}$ and $R_{F B}$
2.. The digital control inputs are diode-protected; however, permanent damage may occur on unconnected inputs from high-energy electrostatic fields. Keep in conductive foam at all times until ready to use.
2. Use proper anti-static handling procedures.
3. Absolute Maximum Ratings apply to both packaged devices and DICE. Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device.

ELECTRICAL CHARACTERISTICS at $V_{D D}=+5 \mathrm{~V} ; \mathrm{V}_{\text {REF }}= \pm 10 \mathrm{~V} ; \mathrm{V}_{\text {OUT }} \mathrm{A}, \mathrm{B}, \mathrm{C}, \mathrm{D}=0 \mathrm{~V} ; \mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ apply for DAC8408AT/BT, $T_{A}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ apply for DAC-8408ET/FT/FP/FPC/FS; $\mathrm{T}_{A}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ apply for DAC-8408GP, unless otherwise noted. Specifications apply for DAC A, B, C, \& D.

| PARAMETER | SYMBOL | CONDITIONS | DAC-8408 |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| STATIC ACCURACY |  |  |  |  |  |  |
| Resolution | $N$ |  | 8 | - | - | Bits |
| Nonlinearity (Notes 1, 2) | INL | DAC-8408A/E/G DAC-8408B/F/H | - | - | $\begin{aligned} & \pm 1 / 4 \\ & \pm 1 / 2 \end{aligned}$ | LSB |
| Differential Nonlinearity | DNL | DAC-8408A/E/G DAC-8408B/F/H | - | - | $\begin{array}{r}  \pm 1 / 2 \\ \pm 1 \end{array}$ | LSB |
| Gain Error | $\mathrm{G}_{\text {FSE }}$ | (Using Internal $\mathrm{R}_{\mathrm{FB}}$ ) | - | - | $\pm 1$ | LSE |
| Gain Tempco (Notes 3, 6) | TC ${ }_{\text {GFS }}$ |  | - | $\pm 2$ | $\pm 40$ | ppm $/{ }^{\circ} \mathrm{C}$ |
| Power Supply Rejection $\left(\Delta V_{D D}= \pm 10 \%\right)$ | PSR |  | - | - | 0.001 | \%FSR/\% |
| Iout 1A, B, C, D Leakage Current (Note 13) | ILKG | $\begin{aligned} & T_{A}=+25^{\circ} \mathrm{C} \\ & T_{A}=\text { Full Temp. Range } \end{aligned}$ | - | - | $\begin{array}{r}  \pm 30 \\ \pm 100 \end{array}$ | $n A$ |

ELECTRICAL CHARACTERISTICS at $V_{D D}=+5 \mathrm{~V} ; \mathrm{V}_{\text {REF }}= \pm 10 \mathrm{~V} ; \mathrm{V}_{\text {OUT }} \mathrm{A}, \mathrm{B}, \mathrm{C}, \mathrm{D}=0 \mathrm{~V} ; \mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ apply for DAC8408AT/BT, $T_{A}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ apply for DAC-8408ET/FT/FP/FPC/FS; $\mathrm{T}_{A}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ apply for DAC-8408GP, unless otherwise noted. Specifications apply for DAC A, B, C, \& D. Continued

| PARAMETER | SYMBOL | CONDITIONS | DAC-8408 |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX |  |
| REFERENCE INPUT |  |  |  |  |  |  |
| Input Voltage Range |  |  | - | - | $\pm 20$ | v |
| Input Resistance Match (Note 4) |  | $R_{\text {A. B. C. D }}$ | - | - | $\pm 1$ | \% |
| Input Resistance | $\mathrm{R}_{\mathrm{IN}}$ |  | 6 | 10 | 14 | k $\Omega$ |
| DIGITAL INPUTS |  |  |  |  |  |  |
| Digital Input Low | $V_{\text {IL }}$ |  | - | - | 0.8 | V |
| Digital Input High | $\mathrm{V}_{\mathrm{IH}}$ |  | 2.4 | - | - | V |
| Input Current (Note 5) | In | $\begin{aligned} & T_{A}=+25^{\circ} \mathrm{C} \\ & T_{A}=\text { Full Temp. Range } \end{aligned}$ | - | $\pm 0.01$ | $\begin{array}{r}  \pm 1.0 \\ \pm 10.0 \end{array}$ | $\mu \mathrm{A}$ |
| Input Capacitance <br> (Note 6) | $\mathrm{C}_{\text {IN }}$ |  | - | - | 8 | pF |
| DATA BUS OUTPUTS |  |  |  |  |  |  |
| Digital Output Low | $\mathrm{V}_{\mathrm{OL}}$ | 1.6mA Sink | - | - | 0.4 | V |
| Digital Output High | $\mathrm{V}_{\mathrm{OH}}$ | $400 \mu \mathrm{~A}$ Source | 4 | - | - | V |
| Output Leakage Current | ILKg | $\begin{aligned} & T_{A}=+25^{\circ} \mathrm{C} \\ & T_{A}=\text { Full Temp. Range } \end{aligned}$ | - | $\begin{aligned} & \pm 0.005 \\ & \pm 0.075 \end{aligned}$ | $\begin{array}{r}  \pm 1.0 \\ \pm 10.0 \end{array}$ | $\mu \mathrm{A}$ |
| DAC OUTPUTS (Note 6) |  |  |  |  |  |  |
| Propagation Delay <br> (Note 7) | $t_{p D}$ |  | - | 150 | 180 | ns |
| Settling Time (Notes 11, 12) | $\mathrm{t}_{\text {s }}$ |  | - | 190 | 250 | ns |
| Output Capacitance | $\mathrm{C}_{\text {OUt }}$ | DAC Latches All "0's" DAC Latches All "1's" | - | - | $\begin{aligned} & 30 \\ & 50 \end{aligned}$ | pF |
| AC Feedthrough | FT | $\left(20 V_{p-p} @ F=100 \mathrm{kHz}\right)$ | 54 | - | - | dB |
| SWITCHING CHARACTERISTICS (Notes 6, 10) |  |  |  |  |  |  |
| Write to Data Strobe Time | $t_{D S 1}$ or ${ }^{\text {t }}$ DS2 | $\begin{aligned} & \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \mathrm{~T}_{\mathrm{A}}=\text { Full Temp. } \text { Range } \end{aligned}$ | $\begin{array}{r} 90 \\ 145 \end{array}$ | - | - | ns |
| Data Valid to Strobe Set-Up Time | ${ }^{\text {tosu }}$ | $\begin{aligned} & \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \mathrm{~T}_{\mathrm{A}}=\text { Full Temp. Range } \end{aligned}$ | $\begin{aligned} & 150 \\ & 175 \end{aligned}$ | - | - | ns |
| Data Valid to Strobe Hold Time | ${ }^{\text {t }} \mathrm{DH}$ |  | 10 | - | - | ns |
| DAC Select to Strobe Set-Up Time | $t_{\text {AS }}$ |  | 0 | - | - | ns |
| DAC Select to Strobe Hold Time | $t_{\text {AH }}$ |  | 0 | - | - | ns |
| Write Select to Strobe Set-Up Time | ${ }^{\text {twsu }}$ |  | 0 | - | - | ns |
| Write Select to Strobe Hold Time | ${ }^{\text {twH }}$ |  | 0 | - | - | ns |

ELECTRICAL CHARACTERISTICS at $V_{D D}=+5 V ; V_{\text {REF }}= \pm 10 \mathrm{~V} ; \mathrm{V}_{\text {OUT }} A, B, C, D=O V ; T_{A}=-55^{\circ} \mathrm{C} 10+125^{\circ} \mathrm{C}$ apply for DAC8408AT/BT, $T_{A}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ apply for DAC-8408ET/FT/FP/FPC/FS; $\mathrm{T}_{A}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ apply for DAC-8408GP, unless otherwise noted. Specifications apply for DAC A, B, C, \& D. Continued

| PARAMETER | SYMBOL | CONDITIONS | DAC-8408 |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | UNITS |
| Read to Data Strobe Width | $t_{\text {RDS }}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | 220 | - | - |  |
|  |  | $\mathrm{T}_{\text {A }}=$ Full Temp. Range | 350 | - | - | ns |
| Data Strobe to Output Valid Time | ${ }^{\text {t }} \mathrm{CO}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | 320 | - | - |  |
|  |  | $\mathrm{T}_{\mathbf{A}}=$ Full Temp. Range | 430 | - | - | ns |
| Output Data to Deselect Time | toto | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | 200 | - | - | ns |
|  |  | $\mathrm{T}_{\mathbf{A}}=$ Full Temp. Range | 270 | - | - | ns |
| Read Select to Strobe Set-Up Time | $t_{\text {RSU }}$ |  | 0 | - | - | ns |
| Read Select to Strobe Hold Time | $t_{\text {RH }}$ |  | 0 | - | - | ns |
| POWER SUPPLY |  |  |  |  |  |  |
| Voltage Range | $V_{\text {DD }}$ |  | 4.5 | - | 5.5 | v |
| Supply Current (Note 8) | $I_{\text {DD }}$ |  | - | - | 50 | $\mu \mathrm{A}$ |
| Supply Current (Note 9) | ${ }^{\text {D }}$ D | $\begin{aligned} & \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \mathrm{~T}_{\mathrm{A}}=\text { Full Temp. Range } \end{aligned}$ | - | - | $\begin{aligned} & 1.0 \\ & 1.5 \end{aligned}$ | mA |

## NOTES: <br> 1. This is an end-point linearity specification.

2. Guaranteed to be monotonic over the full operating temperature range.
3. $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ of FSR ( $\mathrm{FSR}=$ Full Scale Range $=\mathrm{V}_{\text {REF }}-1 \mathrm{LSB}$.)
4. Input Resistance Temperature Coefficient $=+300 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$.
5. Logic Inputs are MOS gates. Typical input current at $+25^{\circ} \mathrm{C}$ is less than $10 n A$.
6. Guaranteed by design.
7. From Digital Input to $90 \%$ of final analog output current.
8. All Digital Inputs " 0 " or $V_{D D}$.
9. All Digital Inputs $\mathrm{V}_{\mathrm{IH}}$ or $\mathrm{V}_{\mathrm{IL}}$.
10. See Timing Diagram.
11. Digital Inputs $=O V$ to $V_{D D}$ or $V_{D D}$ to $O V$.
12. Extrapolated: $\mathrm{t}_{\mathrm{S}}(1 / 2 \mathrm{LSB})=\mathrm{t}_{\mathrm{pD}}+6.2 \tau$ where $\tau=$ the measured first time constant of the final RC decay.
13. All Digital Inputs $=0 \mathrm{~V} ; \mathrm{V}_{\text {REF }}=+10 \mathrm{~V}$.

## BURN-IN CIRCUIT



# Voltage Output with Readback DAC8412/DAC8413 

## FEATURES

+5 to $\pm 15$ Volt Operation
Unipolar or Bipolar Operation
True Voltage Output
Double-Buffered Inputs
Reset to Min or Center Scale
Fast Bus Access Time
Readback

## APPLICATIONS

## Automatic Test Equipment

Digitally Controlled Calibration
Servo Controls
Process Control Equipment

## GENERAL DESCRIPTION

The DAC-8412 and DAC-8413 are quad, 12-bit, voltage output DACs with readback capability. Built using a complementary BiCMOS process, these monolithic DACs offer the user very high package density.

Output voltage swing is set by the two reference inputs $\mathrm{V}_{\text {REFH }}$ and $\mathrm{V}_{\text {REFL }}$. By setting the $\mathrm{V}_{\text {REFL }}$ input to 0 volts and $\mathrm{V}_{\text {REFH }}$ to a positive voltage, the DAC will provide a unipolar positive output range. A similar configuration with $\mathrm{V}_{\mathrm{REFH}}$ at 0 volts and $\mathrm{V}_{\mathrm{REFL}}$ at a negative voltage will provide a unipolar negative output range. Bipolar outputs are configured by connecting both $\mathrm{V}_{\text {REFH }}$ and $\mathrm{V}_{\text {REFL }}$ to nonzero voltages. This method of setting output voltage range has advantages over other bipolar offsetting methods because it is not dependent on internal and external resistors with different temperature coefficients.
Digital controls allow the user to load or read back data from any DAC, load any DAC and transfer data to all DACs at one time.
An active low $\overline{\text { RESET }}$ loads all DAC output registers to midscale for the DAC-8412 and zero scale for the DAC-8413.

The DAC-8412/DAC-8413 are available in 28 -pin plastic DIP, cerdip, PLCC and LCC packages. They can be operated from a


INL VS. CODE OVER TEMPERATURE

## FUNCTIONAL BLOCK DIAGRAM

 ing from single +5 volt to $\pm 15$ volts, and references from +2.5 to $\pm 10$ volts. Power dissipation is less than 330 mW with $\pm 15$ volt supplies and only 60 mW with a +5 volt supply.

For MIL-STD-883 applications, contact your local ADI sales office for the DAC-8412/DAC-8413/883 data sheet which specifies operation over the $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ temperature range. All 883 parts are also available as Standard Military Drawings 5962-91-76401MXA through -76404M3A.

## ORDERING INFORMATION ${ }^{\mathbf{1}}$

| $\begin{aligned} & \text { INL } \\ & \text { (LSB) } \end{aligned}$ | Military ${ }^{2}$ <br> Temperature $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Extended <br> Industrial ${ }^{2}$ <br> Temperature <br> $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Package | Package Option ${ }^{3}$ |
| :---: | :---: | :---: | :---: | :---: |
| $\pm 1$ |  | DAC8412FPC | PLCC | P-28A |
| $\pm 1.5$ | DAC8412BTC/883 |  | LCC | E-28A |
| $\pm 0.5$ |  | DAC8412ET | Cerdip | Q-28 |
| $\pm 0.75$ | DAC8412AT/883 |  | Cerdip | Q-28 |
| $\pm 1$ |  | DAC8412FT | Cerdip | Q-28 |
| $\pm 1.5$ | DAC8412BT/883 |  | Cerdip | Q-28 |
| $\pm 0.5$ |  | DAC8412EP | Plastic | N-28 |
| $\pm 1$ |  | DAC8412FP | Plastic | N-28 |
| $\pm 1$ |  | DAC8412GBC | Dice |  |
| $\pm 1$ |  | DAC8413FPC | PLCC | P-28A |
| $\pm 1.5$ | DAC8413BTC/883 |  | LCC | E-28A |
| $\pm 0.5$ |  | DAC8413ET | Cerdip | Q-28 |
| $\pm 0.75$ | DAC8413AT/883 |  | Cerdip | Q-28 |
| $\pm 1$ |  | DAC8413FT | Cerdip | Q-28 |
| $\pm 1.5$ | DAC8413BT/883 |  | Cerdip | Q-28 |
| $\pm 0.5$ |  | DAC8413EP | Plastic | N-28 |
| $\pm 1$ |  | DAC8413FP | Plastic | N-28 |
| $\pm 1$ |  | DAC8413GBC | Dice |  |

[^58]This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

DAC8412/DAC8413-SPECIFICATIONS
ELECTRICAL CHARACTERISTICS
$\left(@ V_{D D}=+15.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=-15.0 \mathrm{~V}, \mathrm{~V}_{\text {LOGIC }}=+5.0 \mathrm{~V}, \mathrm{~V}_{\text {REF }}=+10.0 \mathrm{~V}, \mathrm{~V}_{\text {REFI }}=-10.0 \mathrm{~V}\right.$, $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ unless otherwise specified. See Note 1 for supply variations.)

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Integral Linearity "E" | INL |  |  | 0.25 | $\pm 0.5$ | LSB |
| Integral Linearity "F" | INL |  |  |  | $\pm 1$ | LSB |
| Differential Linearity | DNL | Monotonic Over Temperature | -1 |  |  | LSB |
| Min Scale Error | $\mathrm{V}_{\text {ZSE }}$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ |  |  | $\pm 2$ | LSB |
| Full-Scale Error | $\mathrm{V}_{\text {FSE }}$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ |  |  | $\pm 2$ | LSB |
| Min Scale Tempco | $\mathrm{TCV}_{\text {ZSE }}$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ |  | 15 |  | ppm/ ${ }^{\circ} \mathrm{C}$ |
| Full-Scale Tempco | TCV ${ }_{\text {FSE }}$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ |  | 20 |  | ppm/ ${ }^{\circ} \mathrm{C}$ |
| MATCHING PERFORMANCE Linearity Matching |  |  |  | $\pm 1$ |  | LSB |
| REFERENCE |  |  |  |  |  |  |
| Positive Reference Input Range |  | Note 2 | $\mathrm{V}_{\mathrm{REFL}}+2.5$ |  | $\mathrm{V}_{\text {DD }}-2.5$ | V |
| Negative Reference Input Range |  | Note 2 | -10 |  | $\mathrm{V}_{\text {REFH }}-2.5$ | V |
| Reference High Input Current | $\mathrm{I}_{\text {REFH }}$ |  | -2.75 | +1.5 | +2.75 | mA |
| Reference Low Input Current | $\mathrm{I}_{\text {REFL }}$ |  | 0 | +2 | +2.75 | mA |
| AMPLIFIER CHARACTERISTICS |  |  |  |  |  |  |
| Output Current | $\mathrm{I}_{\text {OUT }}$ |  | -5 |  | +5 | mA |
| Settling Time | $\mathrm{t}_{\text {S }}$ | to 0.01\% |  | 6 |  | $\mu \mathrm{sec}$ |
| Slew Rate | SR | 10\% to 90\% |  | 2.2 |  | V/ $/ \mathrm{sec}$ |
| LOGIC CHARACTERISTICS |  |  |  |  |  |  |
| Logic Input High Voltage | $\mathrm{V}_{\text {INH }}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | 2.4 |  |  | V |
| Logic Input Low Voltage | $\mathrm{V}_{\text {INL }}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |  |  | 0.8 |  |
| Logic Output High Voltage | $\mathrm{V}_{\mathrm{OH}}$ | $\mathrm{I}_{\mathrm{OH}}=+0.4 \mathrm{~mA}$ | 2.4 |  |  | V |
| Logic Output Low Voltage | $\mathrm{V}_{\mathrm{OL}}$ | $\mathrm{I}_{\mathrm{OL}}=-1.6 \mathrm{~mA}$ |  |  | 0.4 |  |
| Logic Input Current | $\mathrm{I}_{\text {IN }}$ |  |  |  | 1 | $\mu \mathrm{A}$ |
| Input Capacitance | $\mathrm{C}_{\text {IN }}$ |  |  | 8 |  | pF |
| Crosstalk |  |  |  | $>72$ |  | dB |
| Large Signal Bandwidth |  | $-3 \mathrm{~dB}, \mathrm{~V}_{\mathrm{REFH}}=0$ to +10 V p-p |  | 160 |  | kHz |
| LOGIC TIMING CHARACTERISTICS |  | Note 3 |  |  |  |  |
| WRITE |  |  |  |  | - |  |
| Chip Select Write Pulse Width | $\mathrm{t}_{\mathrm{w} C \mathrm{cs}}$ |  | 80 | 40 |  | ns |
| Write Setup | $\mathrm{t}_{\mathrm{ws}}$ | $\mathrm{t}_{\mathrm{wcs}}=80 \mathrm{~ns}$ | 0 |  |  | ns |
| Write Hold | $\mathrm{t}_{\mathrm{WH}}$ | $\mathrm{t}_{\mathrm{wcs}}=80 \mathrm{~ns}$ | 0 |  |  | ns |
| Address Setup | $\mathrm{t}_{\text {AS }}$ |  | 0 |  |  | ns |
| Address Hold | $\mathrm{t}_{\mathrm{AH}}$ |  | 0 |  |  | ns |
| Load Setup | $\mathrm{t}_{\text {LS }}$ |  | 70 | 30 |  | ns |
| Load Hold | $\mathrm{t}_{\text {LH }}$ |  | 30 | 10 |  | ns |
| Write Data Setup | $\mathrm{t}_{\text {wDS }}$ | $\mathrm{t}_{\mathrm{wcs}}=80 \mathrm{~ns}$ | 20 |  |  | ns |
| Write Data Hold | $\mathrm{t}_{\text {wDH }}$ | $\mathrm{t}_{\mathrm{wcs}}=80 \mathrm{~ns}$ | 0 |  |  | ns |
| Load Pulse Width | $\mathrm{t}_{\text {LWD }}$ |  | 170 | 130 |  | ns |
| Reset Pulse Width | $\mathrm{t}_{\text {RESET }}$ |  | 140 | 100 |  | ns |
| READ |  |  |  |  |  |  |
| Chip Select Read Pulse Width | $\mathrm{t}_{\mathrm{RCS}}$ |  | 130 | 100 |  | ns |
| Read Data Hold | $\mathrm{t}_{\text {RDH }}$ | $\mathrm{t}_{\mathrm{RCS}}=130 \mathrm{~ns}$ | 0 |  |  | ns |
| Read Data Setup | $\mathrm{t}_{\text {RDS }}$ | $\mathrm{t}_{\text {RCS }}=130 \mathrm{~ns}$ | 0 |  |  | ns |
| Data to Hi Z | $\mathrm{t}_{\mathrm{DZ}}$ | $\mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}$ |  | 150 |  | ns |
| Chip Select to Data | $\mathrm{t}_{\text {CSD }}$ | $\mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}$ |  | 120 | 160 | ns |
| SUPPLY CHARACTERISTICS |  |  |  |  |  |  |
| Power Supply Sensitivity | PSS | $14.25 \mathrm{~V} \leq \mathrm{V}_{\mathrm{DD}} \leq 15.75 \mathrm{~V}$ |  |  | 150 | ppm/V |
| Positive Supply Current | $\mathrm{I}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{REFH}}=+2.5 \mathrm{~V}$ |  | 8.5 | 12 | mA |
| Negative Supply Current | $\mathrm{I}_{\text {Ss }}$ |  | -10 | -6.5 |  | mA |
| Power Dissipation | $\mathrm{P}_{\text {DISS }}$ |  |  |  | 330 | mW |

[^59]( $@ \mathrm{~V}_{\mathrm{DD}}=\mathrm{V}_{\text {LOGIC }}=+5.0 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{SS}}=0.0 \mathrm{~V}, \mathrm{~V}_{\text {REFH }}=2.5 \mathrm{~V}, \mathrm{~V}_{\text {REFL }}=0.0 \mathrm{~V}$, and $\mathrm{V}_{\text {SS }}=-5.0 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\text {REFL }}=-2.5 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ unless otherwise


| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Integral Linearity "E" | INL |  |  | 1/2 | $\pm 1$ | LSB |
| Integral Linearity "F" | INL |  |  |  | $\pm 2$ | LSB |
| Integral Linearity "E" | INL | $\mathrm{V}_{\text {Ss }}=0.0 \mathrm{~V}$; Note 2 |  |  | $\pm 2$ | LSB |
| Integral Linearity "F" | INL | $\mathrm{V}_{\text {Ss }}=0.0 \mathrm{~V}$; Note 2 |  |  | $\pm 4$ | LSB |
| Differential Linearity | DNL | Monotonic Over Temp | -1 |  |  | LSB |
| Min Scale Error | $\mathrm{V}_{\text {ZSE }}$ | $\mathrm{V}_{\text {SS }}=-5.0 \mathrm{~V}$ |  |  | $\pm 4$ | LSB |
| Full-Scale Error | $\mathrm{V}_{\text {FSE }}$ | $\mathrm{V}_{\text {Ss }}=-5.0 \mathrm{~V}$ |  |  | $\pm 4$ | LSB |
| Min Scale Error | $\mathrm{V}_{\text {ZSE }}$ | $\mathrm{V}_{\text {SS }}=0.0 \mathrm{~V}$ |  |  | $\pm 8$ | LSB |
| Full-Scale Error | $\mathrm{V}_{\text {FSE }}$ | $\mathrm{V}_{\text {Ss }}=0.0 \mathrm{~V}$ |  |  | $\pm 8$ | LSB |
| Min Scale Tempco | $\mathrm{TCV}_{\text {ZSE }}$ |  |  | 100 |  | ppm $/{ }^{\circ} \mathrm{C}$ |
| Full-Scale Tempco | TCV ${ }_{\text {FSE }}$ |  |  | 100 |  | ppm/ ${ }^{\circ} \mathrm{C}$ |
| MATCHING PERFORMANCE Linearity Matching |  |  |  | $\pm 1$ |  | LSB |
| REFERENCE |  |  |  |  |  |  |
| Positive Reference Input Range |  | Note 3 | $\mathrm{V}_{\mathrm{REFL}}+2.5$ |  | $\mathrm{V}_{\mathrm{DD}}-2.5$ | V |
| Negative Reference Input Range |  | $\mathrm{V}_{\text {Ss }}=0.0 \mathrm{~V}$ |  |  | $\mathrm{V}_{\mathrm{REFH}}-2.5$ | V |
| Negative Reference Input Range |  | $\mathrm{V}_{\text {Ss }}=-5.0 \mathrm{~V}$ | -2.5 |  | $\mathrm{V}_{\mathrm{REFH}}-2.5$ | V |
| Reference High Input Current | $\mathrm{I}_{\text {REFH }}$ | Code 000H | -1.0 |  | +1.0 | mA |
| AMPLIFIER CHARACTERISTICS |  |  |  |  |  |  |
| Output Current | $\mathrm{I}_{\text {Out }}$ |  | -1.25 |  | +1.25 | mA |
| Settling Time | ${ }_{\text {t }}$ | to $0.01 \%$ |  | 6 |  | $\mu \mathrm{S}$ |
| Slew Rate | SR | 10\% to 90\% |  | 2.2 |  | V/ $\mu \mathrm{s}$ |
| LOGIC CHARACTERISTICS |  |  |  |  |  |  |
| Logic Input High Voltage | $\mathrm{V}_{\text {INH }}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | 2.4 |  |  | V |
| Logic Input Low Voltage | $\mathrm{V}_{\text {INL }}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |  |  | 0.8 | V |
| Logic Output High Voltage | $\mathrm{V}_{\mathrm{OH}}$ | $\mathrm{I}_{\mathrm{OH}}=+0.4 \mathrm{~mA}$ | 2.4 |  |  | V |
| Logic Output Low Voltage | $\mathrm{V}_{\mathrm{OL}}$ | $\mathrm{I}_{\mathrm{OL}}=-1.6 \mathrm{~mA}$ |  |  | 0.45 | V |
| Logic Input Current | $\mathrm{I}_{\mathrm{IN}}$ |  |  |  | 1 | $\mu \mathrm{A}$ |
| Input Capacitance | $\mathrm{C}_{\text {IN }}$ |  |  | 8 |  | pF |
| LOGIC TIMING CHARACTERISTICS |  | Note 4 |  |  |  |  |
| WRITE |  |  |  |  |  |  |
| Chip Select Write Pulse Width | $\mathrm{t}_{\mathrm{wcs}}$ |  | 150 | 90 |  | ns |
| Write Setup | $\mathrm{t}_{\mathrm{ws}}$ | $\mathrm{t}_{\mathrm{wcs}}=150 \mathrm{~ns}$ | 0 |  |  | ns |
| Write Hold | $\mathrm{t}_{\mathrm{wH}}$ | $\mathrm{t}_{\mathrm{wcs}}=150 \mathrm{~ns}$ | 0 |  |  | ns |
| Address Setup | $\mathrm{t}_{\text {AS }}$ |  | 0 |  |  | ns |
| Address Hold | $\mathrm{t}_{\mathrm{AH}}$ |  | 0 |  |  | ns |
| Load Setup | $\mathrm{t}_{\text {LS }}$ |  | 70 | 30 |  | ns |
| Load Hold | $\mathrm{t}_{\text {LH }}$ |  | 50 | 20 |  | ns |
| Write Data Setup | $\mathrm{t}_{\text {wDS }}$ | $\mathrm{t}_{\mathrm{wcs}}=150 \mathrm{~ns}$ | 20 |  |  | ns |
| Write Data Hold | $\mathrm{t}_{\text {wDH }}$ | $\mathrm{t}_{\mathrm{wcs}}=150 \mathrm{~ns}$ | 0 |  |  | ns |
| Load Pulse Width | $\mathrm{t}_{\text {LWD }}$ |  | 180 | 130 |  | ns |
| Reset Pulse Width | $\mathrm{t}_{\text {RESET }}$ |  | 150 | 110 |  | ns |
| READ |  |  |  |  |  |  |
| Chip Select Read Pulse Width | $\mathrm{t}_{\mathrm{RCS}}$ |  | 170 | 120 |  | ns |
| Read Data Hold | $\mathrm{t}_{\text {RDH }}$ | $\mathrm{t}_{\mathrm{RCS}}=170 \mathrm{~ns}$ | 20 |  |  | ns |
| Read Data Setup | $\mathrm{t}_{\text {RDS }}$ | $\mathrm{t}_{\mathrm{RCS}}=170 \mathrm{~ns}$ | 0 |  |  | ns |
| Data to Hi Z | $\mathrm{t}_{\mathrm{DZ}}$ | $\mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}$ |  | 200 |  | ns |
| Chip Select to Data | $\mathrm{t}_{\text {CSD }}$ | $\mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}$ |  | 220 | 320 | ns |
| SUPPLY CHARACTERISTICS |  |  |  |  |  |  |
| Power Supply Sensitivity | PSS |  |  | 100 |  | ppm/V |
| Positive Supply Current | $\mathrm{I}_{\mathrm{DD}}$ |  |  | 7 | 12 | mA |
| Negative Supply Current | $\mathrm{I}_{\text {ss }}$ | $\mathrm{V}_{\mathrm{ss}}=-5.0 \mathrm{~V}$ | -10 |  |  | mA |

[^60]
## DAC8412/DAC8413

ABSOLUTE MAXIMUM RATINGS ${ }^{1}$
( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)
$\mathrm{V}_{\mathrm{SS}}$ to $\mathrm{V}_{\mathrm{DD}}$. . . . . . . . . . . . . . . . . . . . . $-0.3 \mathrm{~V},+33.0 \mathrm{~V}$

$\mathrm{V}_{\text {LOGIC }}$ to DGND . . . . . . . . . . . . . . . . . $-0.3 \mathrm{~V},+18.0 \mathrm{~V}$
$\mathrm{V}_{\text {SS }}$ to $\mathrm{V}_{\text {REFL }}$. . . . . . . . . . . . . . . . . $-0.3 \mathrm{~V},+\mathrm{V}_{\mathrm{SS}}-2.0 \mathrm{~V}$
$\mathrm{V}_{\text {REFH }}$ to $\mathrm{V}_{\mathrm{DD}} \ldots . . . . . . . . . . . . . . . .+2.0 \mathrm{~V},+33.0 \mathrm{~V}$
$\mathrm{V}_{\text {REFH }}$ to $\mathrm{V}_{\mathrm{REFL}} \ldots . . . . . . . . . . . .+2.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}-\mathrm{V}_{\mathrm{DD}}$
Current into Any Pin ${ }^{4}$. . . . . . . . . . . . . . . . . . . . . $\pm 15 \mathrm{~mA}$
Digital Input Voltage to DGND . . . $-0.3 \mathrm{~V}, \mathrm{~V}_{\text {LOGIC }}+0.3 \mathrm{~V}$
Digital Output Voltage to DGND . . . . . . . $-0.3 \mathrm{~V},+7.0 \mathrm{~V}$
Operating Temperature Range
ET, FT, EP, FP, FPC . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
AT, BT, BTC . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Dice Junction Temperature . . . . . . . . . . . . . . . . . . $+150^{\circ} \mathrm{C}$
Storage Temperature . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Power Dissipation Package . . . . . . . . . . . . . . . . . 1000 mW
Lead Temperature (Soldering, 60 sec) . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Thermal Resistance

| Package Type | $\boldsymbol{\theta}_{\mathbf{J A}}{ }^{\mathbf{1}}$ | $\boldsymbol{\theta}_{\mathbf{J C}}$ | Units |
| :--- | :---: | :---: | :---: |
| 28-Pin Hermetic DIP (T) | 50 | 7 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 28-Pin Plastic DIP (P) | 48 | 22 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 28-Lead Hermetic Leadless Chip Carrier (TC) | 70 | 28 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 28-Lead Plastic Leaded Chip Carrier (PC) | 63 | 25 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTE

${ }^{1} \theta_{\mathrm{JA}}$ is specified for worst case mounting conditions, i.e., $\theta_{\mathrm{JA}}$ is specified for device in socket.

## TIMING DIAGRAMS



Data Output (Read) Timing


Data WRITE (Input and Output Registers) Timing

## CAUTION

1. Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation at or above this specification is not implied. Exposure to the above maximum rating conditions for extended periods may affect device reliability.
2. Digital inputs and outputs are protected, however, permanent damage may occur on unprotected units from high-energy electrostatic fields. Keep units in conductive foam or packaging at all times until ready to use. Use proper antistatic handling procedures.

3. Remove power before inserting or removing units from their sockets.
4. Analog outputs are protected from short circuit to ground or either supply.

PIN CONFIGURATIONS


## FEATURES

## Guaranteed Monotonic Over Temperature Excellent Matching Between DACs Unipolar or Bipolar Operation Buffered Voltage Outputs <br> High Speed Serial Digital Interface Reset to Zero- or Center-Scale Wide Supply Range, +5 V-Only to $\pm 15 \mathrm{~V}$ Low Power Consumption ( 35 mW max) Available in $\mathbf{1 6 - P i n}$ DIP and SOL Packages

## APPLICATIONS

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Software Controlled Calibration
Servo Controls
Process Control and Automation
ATE
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## GENERAL DESCRIPTION

The DAC-8420 is a quad, 12 -bit voltage-output DAC with serial digital interface, in a 16-pin package. Utilizing BiCMOS technology, this monolithic device features unusually high circuit density and low power consumption. The simple, easy-to-use serial digital input and fully buffered analog voltage outputs require no external components to achieve specified performance.
The three-wire serial digital input is easily interfaced to microprocessors running at 10 MHz rates, with minimal additional circuitry. Each DAC is addressed individually by a 16 -bit serial word consisting of a 12 -bit data word and an address header. The user-programmable reset control $\overline{\text { CLR }}$ forces all four DAC outputs to either zero- or midscale, asynchronously overriding the current DAC register values. The output voltage range, determined by the inputs VREFHI and VREFLO, is set by the user for positive or negative unipolar or bipolar signal swings within the supplies allowing considerable design flexibility.

FUNCTIONAL BLOCK DIAGRAM


The DAC-8420 is available in 16-pin epoxy DIP, cerdip, and wide-body SOL (small-outline surface mount) packages. Operation is specified with supplies ranging from +5 V -only to $\pm 15 \mathrm{~V}$, with references of +2.5 V to $\pm 10 \mathrm{~V}$ respectively. Power dissipation when operating from $\pm 15 \mathrm{~V}$ supplies is less than 255 mW (max), and only 35 mW (max) with a +5 V supply.
For applications requiring product meeting MIL-STD-883, contact your local sales office for the DAC-8420/883 data sheet, which specifies operation over the $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ temperature range.

## DAC8420-SPECIFICATIONS

ELECTRICAL CHARACTERISTICS (at $\mathrm{V}_{00}=+5.0 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{SS}}=0.0 \mathrm{~V}, \mathrm{~V}_{\text {vREFHI }}=+2.5 \mathrm{~V}, \mathrm{~V}_{\text {VREFLO }}=0.0 \mathrm{~V}$, and
$V_{\text {ss }}=-5.0 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\text {veffio }}=-2.5 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ unless otherwise noted. See Note 1 for supply variations.)

| Parameter | Symbol | Condition | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| STATIC ACCURACY |  |  |  |  |  |  |
| Integral Linearity "E" | INL |  |  | $\pm 1 / 4$ | $\pm 1$ | LSB |
| Integral Linearity "E" | INL | Note 2, $\mathrm{V}_{\text {Ss }}=0 \mathrm{~V}$ |  | $\pm 1 / 2$ | $\pm 3$ | LSB |
| Integral Linearity "F" | INL |  |  | $\pm 3 / 4$ | $\pm 2$ | LSB |
| Integral Linearity "F" | INL | Note 2, $\mathrm{V}_{\text {Ss }}=0 \mathrm{~V}$ |  | $\pm 1$ | $\pm 4$ | LSB |
| Differential Linearity | DNL | Monotonic Over Temperature |  | $\pm 1 / 4$ | $\pm 1$ | LSB |
| Min-Scale Error | ZSE | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{V}_{\text {Ss }}=-5 \mathrm{~V}$ |  |  | $\pm 4$ | LSB |
| Full-Scale Error | FSE | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{V}_{\mathrm{SS}}=-5 \mathrm{~V}$ |  |  | $\pm 4$ | LSB |
| Min-Scale Error | ZSE | Note 2, $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{V}_{\text {Ss }}=0 \mathrm{~V}$ |  |  | +8 | LSB |
| Full-Scale Error | FSE | Note 2, $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{V}_{\text {ss }}=0 \mathrm{~V}$ |  |  | $\pm 8$ | LSB |
| Min-Scale Tempco | $\mathrm{TC}_{\text {zSE }}$ | Note 3, $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{V}_{\mathrm{SS}}=-5 \mathrm{~V}$ |  | $\pm 10$ |  | ppm/ ${ }^{\circ} \mathrm{C}$ |
| Full-Scale Tempco | $\mathrm{TC}_{\text {FSE }}$ | Note 3, $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{V}_{\text {Ss }}=-5 \mathrm{~V}$ |  | $\pm 10$ |  | ppm $/{ }^{\circ} \mathrm{C}$ |
| MATCHING PERFORMANCE Linearity Matching |  |  |  | $\pm 1$ |  | LSB |
| REFERENCE |  |  |  |  |  |  |
| Positive Reference Input Range | $\mathrm{V}_{\text {VREFHI }}$ | Note 4 | $\mathrm{V}_{\text {VREFLO }}+2.5$ |  | $\mathrm{V}_{\mathrm{DD}}$-2.5 | V |
| Negative Reference Input Range | $\mathrm{V}_{\text {VREFLO }}$ | Note 4 | $\mathrm{V}_{\text {ss }}$ |  | $\mathrm{V}_{\text {VREFHI }}-2.5$ | V |
| Negative Reference Input Range | $V_{\text {vREFLO }}$ | Note 4, $\mathrm{V}_{\text {ss }}=0 \mathrm{~V}$ |  |  | $\mathrm{V}_{\mathrm{VREFHI}}-2.5$ |  |
| Reference High Input Current | $\mathrm{I}_{\text {VREFHI }}$ | Codes $000{ }_{\mathrm{H}}, 555{ }_{\mathrm{H}}$ | -0.75 | $\pm 0.25$ | $+0.75$ | mA |
| Reference Low Input Current | $\mathrm{I}_{\text {VREFLO }}$ | Codes $000_{\mathrm{H}}, 555 \mathrm{H}_{\mathrm{H}}, \mathrm{V}_{\text {Ss }}=-5 \mathrm{~V}$ | -1.0 | -0.6 |  | mA |
| AMPLIFIER CHARACTERISTICS |  |  |  |  |  |  |
| Output Current | $\mathrm{I}_{\text {OUT }}$ | $\mathrm{V}_{\mathrm{ss}}=-5 \mathrm{~V}$ | -1.25 |  | +1.25 | mA |
| Settling Time | ${ }_{\text {t }}^{\text {s }}$ | to $0.01 \%$, Note 5 |  | 8 |  | $\mu \mathrm{s}$ |
| Slew Rate | SR | 10\% to $90 \%$, Note 5 |  | 1.5 |  | V/us |
| LOGIC CHARACTERISTICS |  |  |  |  |  |  |
| Logic Input High Voltage | $\mathrm{V}_{\text {INH }}$ |  | 2.4 |  |  | V |
| Logic Input Low Voltage | $\mathrm{V}_{\text {INL }}$ |  |  |  | 0.8 | V |
| Logic Input Current | $\mathrm{I}_{\mathrm{IN}}$ |  |  |  | 10 | $\mu \mathrm{A}$ |
| Input Capacitance | $\mathrm{C}_{\text {IN }}$ | Note 3 |  | 13 |  | pF |
| LOGIC TIMING CHARACTERISTICS ${ }^{3,6}$ |  |  |  |  |  |  |
| Data Setup Time | $\mathrm{t}_{\mathrm{DS}}$ | " | 25 |  |  | ns |
| Data Hold | $\mathrm{t}_{\mathrm{DH}}$ |  | 55 |  |  | ns |
| Clock Pulse Width HIGH | $\mathrm{t}_{\mathrm{CH}}$ |  | 90 |  |  | ns |
| Clock Pulse Width LOW | $\mathrm{t}_{\mathrm{CL}}$ |  | 120 |  |  | ns |
| Select Time | $\mathrm{t}_{\mathrm{Css}}$ |  | 90 |  |  | ns |
| Deselect Delay | $\mathrm{t}_{\text {cSH }}$ |  | 5 |  |  | ns |
| Load Disable Time | $\mathrm{t}_{\text {LD1 }}$ |  | 130 |  |  | ns |
| Load Delay | $\mathrm{t}_{\text {LD2 }}$ |  | 35 |  |  | ns |
| Load Pulse Width | $\mathrm{t}_{\text {LDW }}$ |  | 80 |  |  | ns |
| Clear Pulse Width | $\mathrm{t}_{\text {clew }}$ |  |  |  |  | ns |
| SUPPLY CHARACTERISTICS |  |  |  |  |  |  |
| Power Supply Sensitivity | PSRR |  |  | 0.002 | 0.01 | \%/\% |
| Positive Supply Current | $\mathrm{I}_{\mathrm{DD}}$ |  |  |  | 7 | mA |
| Negative Supply Current | $\mathrm{I}_{\text {Ss }}$ |  | -6 | $-3$ |  | $\mathrm{mA}$ |
| Power Dissipation | $\mathrm{P}_{\text {DISS }}$ | $\mathrm{V}_{\mathrm{ss}}=0 \mathrm{~V}$ |  |  | 35 | mW |

[^61]ELECTRICAL CHARACTERISTICS (at $\mathrm{v}_{\mathrm{DD}}=+15.0 \mathrm{v} \pm 5 \%, \mathrm{v}_{\mathrm{SS}}=-15.0 \mathrm{v} \pm 5 \%, \mathrm{v}_{\text {vRefrl }}=+10.0 \mathrm{v}$,
$V_{\text {veeflo }}=-10.0 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ unless otherwise noted. See Note 1 for supply variations.)

| Parameter | Symbol | Condition | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| STATIC ACCURACY <br> Integral Linearity "E" Integral Linearity " $F$ " Differential Linearity Min-Scale Error Full-Scale Error Min-Scale Tempco Full-Scale Tempco | $\begin{array}{\|l} \text { INL } \\ \text { INL } \\ \text { DNL } \\ \text { ZSE } \\ \text { FSE } \\ \text { TC }_{\text {ZSE }} \\ \text { TC }_{\text {FSE }} \\ \hline \end{array}$ | Monotonic Over Temperature $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \end{aligned}$ <br> Note $2, \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ <br> Note $2, \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ |  | $\begin{aligned} & \pm 1 / 4 \\ & \pm 1 / 2 \\ & \pm 1 / 4 \\ & \\ & \pm 4 \\ & \pm 4 \end{aligned}$ | $\begin{aligned} & \pm 1 / 2 \\ & \pm 1 \\ & \pm 1 \\ & \pm 2 \\ & \pm 2 \end{aligned}$ | LSB <br> LSB <br> LSB <br> LSB <br> LSB <br> ppm $/{ }^{\circ} \mathrm{C}$ <br> ppm $/{ }^{\circ} \mathrm{C}$ |
| MATCHING PERFORMANCE Linearity Matching |  |  |  | $\pm 1$ |  | LSB |
| REFERENCE <br> Positive Reference Input Range Negative Reference Input Range Reference High Input Current Reference Low Input Current | $\mathrm{V}_{\text {VREFHI }}$ <br> $V_{\text {VREFLO }}$ <br> $I_{\text {VREFHI }}$ <br> IVREFLO | Note 3 <br> Note 3 <br> Code $000_{\mathrm{H}}, 555_{\mathrm{H}}$ <br> Code $000_{\mathrm{H}}, 555_{\mathrm{H}}$ | $\begin{aligned} & \mathrm{V}_{\text {VREFLO }}+2.5 \\ & -10 \\ & -2.0 \\ & -3.5 \end{aligned}$ | $\begin{array}{r}  \pm 1.0 \\ -2.0 \end{array}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}-2.5 \\ & \mathrm{~V}_{\mathrm{VREFHI}}-2.5 \\ & +2.0 \end{aligned}$ | $\left\{\begin{array}{l} \mathrm{V} \\ \mathrm{~V} \\ \mathrm{~mA} \\ \mathrm{~mA} \end{array}\right.$ |
| AMPLIFIER CHARACTERISTICS <br> Output Current Settling Time Slew Rate | $\begin{array}{\|l} \mathrm{I}_{\text {OUT }} \\ \mathrm{t}_{\mathbf{S}} \\ \mathrm{SR} \end{array}$ | to $0.01 \%$, Note 4 $10 \%$ to $90 \%$, Note 4 | $-5$ | $\begin{aligned} & 13 \\ & 2 \end{aligned}$ | +5 | $\begin{array}{\|l} \mathrm{mA} \\ \mu \mathrm{~s} \\ \mathrm{~V} / \mu \mathrm{s} \end{array}$ |
| DYNAMIC PERFORMANCE <br> Analog Crosstalk Digital Feedthrough Large Signal Bandwidth Glitch Impulse |  | Note 2 <br> Note 2 $\begin{aligned} & -3 \mathrm{~dB}, \mathrm{~V}_{\mathrm{VREFHI}}=5 \mathrm{~V}+10 \mathrm{~V} \mathrm{p}-\mathrm{p}, \\ & \mathrm{~V}_{\mathrm{VREFLO}}=-10 \mathrm{~V}, \text { Note } 2 \\ & \text { Code Transition }=7 \mathrm{FF}_{\mathrm{H}} \text { to } 800_{\mathrm{H}}, \text { Note } 2 \end{aligned}$ |  | $\begin{aligned} & >64 \\ & >72 \\ & 90 \\ & 64 \end{aligned}$ |  | $\begin{array}{\|l} \mathrm{dB} \\ \mathrm{~dB} \\ \mathrm{kHz} \\ \mathrm{nV}-\mathrm{s} \end{array}$ |
| LOGIC CHARACTERISTICS <br> Logic Input High Voltage Logic Input Low Voltage Logic Input Current Input Capacitance | $\left\lvert\, \begin{aligned} & \mathrm{V}_{\mathrm{INH}} \\ & \mathrm{~V}_{\mathrm{INL}} \\ & \mathrm{I}_{\mathrm{IN}} \\ & \mathrm{C}_{\mathrm{IN}} \end{aligned}\right.$ | Note 2 | 2.4 | $13$ | $\begin{aligned} & 0.8 \\ & 10 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{\mu A} \\ & \mathrm{pF} \end{aligned}$ |
| LOGICTIMING CHARACTERISTICS ${ }^{2,5}$ <br> Data Setup Time <br> Data Hold <br> Clock Pulse Width HIGH <br> Clock Pulse Width LOW <br> Select Time <br> Deselect Delay <br> Load Disable Time <br> Load Delay <br> Load Pulse Width <br> Clear Pulse Width | $t_{\text {DS }}$ <br> $t^{t_{D H}}$ <br> $\mathrm{t}_{\mathrm{CH}}$ <br> ${ }^{t_{C L}}$ <br> ${ }^{t_{\text {Css }}}$ <br> $\mathrm{t}_{\mathrm{CSH}}$ <br> ${ }^{\text {t }}$ LD1 <br> $t_{\text {LD2 }}$ <br> $t_{\text {LDW }}$ <br> ${ }^{\text {t CLRW }}$ |  | $\begin{aligned} & 25 \\ & 20 \\ & 30 \\ & 50 \\ & 55 \\ & 15 \\ & 40 \\ & 15 \\ & 45 \\ & 70 \end{aligned}$ |  |  | $\begin{aligned} & \text { ns } \\ & \text { ns } \\ & \text { ns } \\ & \text { ns } \\ & \text { ns } \\ & \text { ns } \\ & \text { ns } \\ & \text { ns } \\ & \text { ns } \\ & \text { ns } \end{aligned}$ |
| SUPPLY CHARACTERISTICS <br> Power Supply Sensitivity Positive Supply Current Negative Supply Current Power Dissipation | PSRR <br> $I_{D D}$ <br> $\mathrm{I}_{\text {ss }}$ <br> $P_{\text {DISS }}$ |  | -8 | $\begin{aligned} & 0.002 \\ & 6 \\ & -5 \end{aligned}$ | $\begin{aligned} & 0.01 \\ & 9 \\ & 255 \end{aligned}$ | $\begin{aligned} & \% / \% \\ & \mathrm{~mA} \\ & \mathrm{~mA} \\ & \mathrm{~mW} \end{aligned}$ |

[^62]WAFER TEST LIMITS ${ }_{\text {(at }} \mathrm{V}_{\mathrm{DD}}=+15.0 \mathrm{~V}, \mathrm{~V}_{\text {SS }}=-15.0 \mathrm{~V}, \mathrm{~V}_{\text {REFHI }}=+10.0 \mathrm{~V}, \mathrm{~V}_{\text {REFLO }}=-10.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$,
WAFER TEST LIMITS unness oftemise noted),

| Parameter | Symbol | Conditions | DAC-8420G <br> Limit | Units |
| :---: | :---: | :---: | :---: | :---: |
| Integral Linearity | INL |  | $\pm 1$ | LSB max |
| Differential Linearity | DNL |  | $\pm 1$ | LSB max |
| Min-Scale Offset |  |  | $\pm 1$ | LSB max |
| Max-Scale Offset |  |  | $\pm 1$ | LSB max |
| Logic Input High Voltage | $\mathrm{V}_{\text {INH }}$ |  | 2.4 | V min |
| Logic Input Low Voltage | $\mathrm{V}_{\text {INL }}$ |  | 0.8 | $V$ max |
| Logic Input Current | $\mathrm{I}_{\mathrm{IN}}$ |  | 1 | $\mu \mathrm{A}$ max |
| Positive Supply Current | $\mathrm{I}_{\mathrm{DD}}$ |  | 8 | $m A \max$ |
| Negative Supply Current | $\mathrm{I}_{\text {SS }}$ |  | 7 | $m A \max$ |

NOTE:
Electrical tests are performed at wafer probe to the limits shown. Due to variations in assembly methods and normal yield loss, yield after packaging is not guaranteed for standard product dice. Consult factory to negotiate specifications based on dice lot qualification through sample lot assembly and testing.'

## ABSOLUTE MAXIMUM RATINGS

( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise noted)
VDD to GND . . . . . . . . . . . . . . . . . . . $-0.3 \mathrm{~V},+18.0 \mathrm{~V}$
VSS to GND . . . . . . . . . . . . . . . $+1.3 \mathrm{~V},-18.0 \mathrm{~V}$
VSS to VDD . . . . . . . . . . . . $-0.3 \mathrm{~V},+36.0 \mathrm{~V}$

$\mathrm{V}_{\text {VREFHI }}$ to $\mathrm{V}_{\text {VReflo }} . . . . . . . . . . . . . . . .+2.0 \mathrm{~V}, \mathrm{~V}_{\text {DD }}-\mathrm{V}_{\text {SS }}$
$\mathrm{V}_{\text {VREFHI }}$ to $\mathrm{V}_{\mathrm{DD}} \ldots \ldots . . . . . . . . . . .+2.0 \mathrm{~V},+33.0 \mathrm{~V}$
$\mathrm{I}_{\text {VREFHI }}, \mathrm{I}_{\text {VREFLO }}$. . . . . . . . . . . . . . . . . . . . . . . . . 10 mA
Digital Input Voltage to GND . . . . . . $-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Output Short Circuit Duration . . . . . . . . . . . . . . . Indefinite Operating Temperature Range

EP, FP, ES, FS, EQ, FQ . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Dice Junction Temperature . . . . . . . . . . . . . . . . . . $+150^{\circ} \mathrm{C}$
Storage Temperature . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Power Dissipation . . . . . . . . . . . . . . . . . . . . . . . 1000 mW
Lead Temperature (Soldering, 60 sec ) . . . . . . . . . . . . . 300 ${ }^{\circ} \mathrm{C}$

|  | Thermal Resistance |  |  |
| :--- | :--- | :---: | :---: |
| Package Type | $\boldsymbol{\theta}_{\mathbf{J A}}$ | $\boldsymbol{\theta}_{\mathbf{J C}}$ | Units |
| 16-Pin Plastic DIP (P) | $70^{1}$ | 27 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 16-Pin Hermetic DIP (Q) | $82^{1}$ | 9 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 16-Lead Small Outline <br> Surface Mount (S) | $86^{2}$ | 22 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTES

${ }^{1} \theta_{\mathrm{JA}}$ is specified for worst case mounting conditions, i.e., $\theta_{\mathrm{JA}}$ is specified for device in socket.
${ }^{2} \theta_{J A}$ is specified for device on board.

## CAUTION

1. Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation at or above this specification is not implied. Exposure to the above maximum rating conditions for extended periods may affect device reliability.
2. Digital inputs and outputs are protected, however, permanent damage may occur on unprotected units from high-energy electrostatic fields. Keep units in conductive foam or packaging at all times until ready to use. Use proper antistatic handling procedures.
3. Remove power before inserting or removing units from their sockets.
4. Analog Outputs are protected from short circuits to ground or either supply.

## DICE CHARACTERISTICS



Die Size $0.119 \times 0.283$ inch, 33,677 sq. mils ( $3.023 \times 7.188 \mathrm{~mm}, 21.73 \mathrm{sq}$. mm) Transistor Count 2,207
For additional DICE ordering information, refer to databook.

## DATA LOAD SEQUENCE



Timing Diagram


Burn-In Diagram

## PIN CONFIGURATIONS




## PIN FUNCTION DESCRIPTION



Table I. Control Function Logic Table

| CLK $^{\mathbf{1}}$ | $\overline{\mathbf{C S}}^{\mathbf{1}}$ | $\overline{\text { LD }}$ | $\overline{\text { CLR }}$ | CLSEL | Serial Input Shift Register | DAC Registers A-D |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| NC | H | H | L | H | No Change | Loads Midscale Value $\left(800_{H}\right)$ |
| NC | H | H | L | L | No Change |  |
| NC | H | H | $\uparrow$ | H/L | No Change | Loads Zero-Scale Value $\left(000_{H}\right)$ |
| $\uparrow$ | L | H | H | NC | Shifts Register One Bit. | Latches Value |
| Lo Change |  |  |  |  |  |  |
| H | $\uparrow$ | H | H | NC | Shifts Register One Bit. | No Change |
| H | NC $(\uparrow)$ | $\downarrow$ | H | NC | No Change | Loads the Serial Data Word ${ }^{2}$ |
| NC | NC | H | H | NC | No Change | Transparent ${ }^{3}$ |

NC = Don't Care.
NOTES
${ }^{1} \mathrm{CS}$ and CLK are interchangeable.
${ }^{2}$ Returning CS HIGH while CLK is HIGH avoids an additional "false clock" of serial input data. See Note 1.
${ }^{3}$ Do not clock in serial data while $\overline{\mathrm{LD}}$ is LOW.

## OPERATION

## Introduction

The DAC-8420 is a quad, voltage-output 12 -bit DAC with serial digital input, capable of operating from a single +5 V supply. The straightforward serial interface can be connected directly to most popular microprocessors and microcontrollers, and can accept data at a 10 MHz clock rate when operating from $\pm 15 \mathrm{~V}$ supplies. A unique voltage reference structure assures maximum utilization of DAC output resolution by allowing the user to set the zero- and full-scale output levels within the supply rails. The analog voltage outputs are fully buffered, and are capable of driving a $2 \mathrm{k} \Omega$ load. Output glitch impulse during major code transitions is a very low 64 nV -s (typ).

## Digital Interface Operation

The serial input of the DAC-8420, consisting of $\overline{C S}$, SDI, and $\overline{L D}$, is easily interfaced to a wide variety of microprocessor serial ports. As shown in Table I and the Timing Diagram, while $\overline{\mathrm{CS}}$ is LOW the data presented to the input SDI is shifted into the internal serial/parallel shift register on the rising edge of the clock, with the address MSB first, data LSB last. The data format, shown above, is two bits of DAC address and two "don't care" fill bits, followed by the 12 -bit DAC data word. Once all 16 bits of the serial data word have been input, the load control $\overline{\mathrm{LD}}$ is strobed and the word is parallel-shifted out onto the internal data bus. The two address bits are decoded and used to route the 12 -bit data word to the appropriate DAC data register. See the Applications Information.

## Correct Operation of $\overline{\text { CS }}$ and CLK

As mentioned in Table I, the control pins CLK and $\overline{C S}$ require some attention during a data load cycle. Since these two inputs are fed to the same logical "OR" gate, their operation is in fact identical. The user must take care to operate them accordingly in order to avoid clocking in false data bits. As shown in the Timing Diagram, CLK must be either halted HIGH, or $\overline{\mathrm{CS}}$ brought HIGH during the last HIGH portion of the CLK following the rising edge which latched in the last data bit. Otherwise, an additional rising edge is generated by $\overline{\mathrm{CS}}$ rising while CLK is LOW, causing $\overline{C S}$ to act as the clock and allowing a false data bit into the serial input register. The same issue must be considered in the beginning of the data load sequence also.

## Using $\overline{\text { CLR }}$ and CLSEL

The CLEAR ( $\overline{\mathrm{CLR}}$ ) control allows the user to perform an asynchronous reset function. Asserting $\overline{\mathrm{CLR}}$ loads all four DAC data word registers, forcing the DAC outputs to either zero-scale $\left(000_{\mathrm{H}}\right)$ or midscale $\left(800_{\mathrm{H}}\right)$, depending on the state of CLSEL as shown in the Digital Function Table. The CLEAR function is
asynchronous and is totally independent of $\overline{\mathrm{CS}}$. When $\overline{\mathrm{CLR}}$ returns HIGH, the DAC outputs remain latched at the reset value until $\overline{\mathrm{LD}}$ is strobed, reloading the individual DAC data word registers with either the data held in the serial input register prior to the reset, or new data loaded through the serial interface.

Table II. DAC Address Word Decode Table

| A1 | A0 | DAC Addressed |
| :--- | :--- | :--- |
| 0 | 0 | DAC A |
| 0 | 1 | DAC B |
| 1 | 0 | DAC C |
| 1 | 1 | DAC D |

## Programming the Analog Outputs

The unique differential reference structure of the DAC-8420 allows the user to tailor the output voltage range precisely to the needs of the application. Instead of spending DAC resolution on an unused region near the positive or negative rail, the DAC8420 allows the user to determine both the upper and lower limits of the analog output voltage range. Thus, as shown in Table III and Figure 1, the outputs of DACs A through D range between VREFHI and VREFLO, within the limits specified in the Electrical Characteristics tables. Note also that VREFHI must be greater than VREFLO.


Figure 1. Output Voltage Range Programming

Table III. Analog Output Code

| DAC Data Word (HEX) | Vout | Note |
| :--- | :--- | :--- |
| FFF | $V R E F L O+\frac{(V R E F H I-V R E F L O)}{4096} \times 4095$ | Full-Scale Output |
| 801 | $V R E F L O+\frac{(V R E F H I-V R E F L O)}{4096} \times 2049$ | Midscale +1 |
| 800 | $V R E F L O+\frac{(V R E F H I-V R E F L O)}{4096} \times 2048$ | Midscale |
| 7 FF | $V R E F L O+\frac{(V R E F H I-V R E F L O)}{4096} \times 2047$ | Midscale -1 |
| 000 | $V R E F L O+\frac{(V R E F H I-V R E F L O)}{4096} \times 0$ | Zero-Scale |

## Typical Performance Characteristics



Figure 2. Differential Linearity vs. VREFHI ( $\pm 15$ V)


Figure 5. INL vs. VREFHI (+5 V)


Figure 3. Differential Linearity vs. VREFHI ( +5 V)


Figure 6. Full-Scale Error vs. Time Accelerated by Burn-In


Figure 4. INL vs. VREFHI ( $\pm 15 \mathrm{~V}$ )


Figure 7. Zero-Scale Error vs. Time Accelerated by Burn-In


Figure 8. Full-Scale Error vs. Temperature


Figure 11. Channel-to-Channel Matching +5/+2.5


Figure 14. $I_{\text {VREFHI }}$ vs. Code


Figure 9. Zero-Scale Error vs. Temperature


Figure 12. $I_{D D}$ vs. $V_{\text {VREFHI }}$ All DACs HIGH


Figure 15. Settling Time $(+)( \pm 5$ V)


Figure 10. Channel-to-Channel
Matching $\pm 15 / \pm 10$


Figure 13. INL vs. Code $\pm 15 / \pm 10$


Figure 16. Settling Time $(-)( \pm 5 \mathrm{~V})$


Figure 17. Settling Time $(+)( \pm 15$ V)


Figure 18. Settling Time $(-)( \pm 15 \mathrm{~V})$


Figure 21. Small-Signal Response

Figure 24. DAC Output Current vs.
VOUTX



Figure 23. Power Supply Current vs. Temperature


Figure 19. Slew Rate ( $\pm 5 \mathrm{~V}$ )


Figure 22. PSRR vs. Frequency


Figure 25. Output Swing vs. Load Resistance

## VREFHI Input Requirements

The DAC-8420 utilizes a unique, patented DAC switch driver circuit which compensates for different supply, reference voltage, and digital code inputs. This ensures that all DAC ladder switches are always biased equally, ensuring excellent linearity under all conditions. Thus, as indicated in the specifications, the VREFHI input of the DAC-8420 will require both sourcing and sinking current capability from the reference voltage source. Many positive voltage references are intended as current sources only, and offer little sinking capability. The user should consider references such as the AD584, AD586, AD587, AD588, AD780, and REF-43 in this application.

## APPLICATIONS

## Power Supply Bypassing and Grounding

In any circuit where accuracy is important, careful consideration of the power supply and ground return layout helps to ensure the rated performance. The DAC-8420 has a single ground pin that is internally connected to the digital section as the logic reference level. The first thought may be to connect this pin to the digital ground; however, in large systems the digital ground is often noisy because of the switching currents of other digital circuitry. Any noise that is introduced at the ground pin could couple into the analog output. Thus, to avoid error causing digital noise in the sensitive analog circuitry, the ground pin should be connected to the system analog ground. The ground path (circuit board trace) should be as wide as possible to reduce any effects of parasitic inductance and ohmic drops. A ground plane is recommended if possible. The noise immunity of the on-board digital circuitry, typically in the hundreds of millivolts, is well able to reject the common-mode noise typically seen between system analog and digital grounds. Finally, the analog and digital ground should be connected together at a single point in the system to provide a common reference. This is preferably done at the power supply.
Good grounding practice is essential to maintaining analog performance in the surrounding analog support circuitry as well. With two reference inputs, and four analog outputs capable of moderate bandwidth and output current, there is a significant potential for ground loops. Again, a ground plane is recommended as the most effective solution to minimizing errors due to noise and ground offsets.


Figure 26. Recommended Supply Bypassing Scheme

The DAC- 8420 should have ample supply bypassing, located as close to the package as possible. Figure 26 shows the recommended capacitor values of $10 \mu \mathrm{~F}$ in parallel with $0.1 \mu \mathrm{~F}$. The $0.1 \mu \mathrm{~F}$ cap should have low "Effective Series Resistance" (ESR) and "Effective Series Inductance" (ESI), such as the common ceramic types, which provide a low impedance path to ground at high frequencies to handle transient currents due to internal logic switching. In order to preserve the specified analog performance of the device, the supply should be as noise free as possible. In the case of 5 V only systems it is desirable to use the same 5 V supply for both the analog circuitry and the digital portion of the circuit. Unfortunately, the typical 5 V supply is extremely noisy due to the fast edge rates of the popular CMOS logic families which induce large inductive voltage spikes, and busy microcontroller or microprocessor busses which commonly have large current spikes during bus activity. However, by properly filtering the supply as shown in Figure 27, the digital 5 V supply can be used. The inductors and capacitors generate a filter that not only rejects noise due to the digital circuitry, but also filters out the lower frequency noise of switch mode power supplies. The analog supply should be connected as close as possible to the origin of the digital supply to minimize noise pick-up from the digital section.


Figure 27. Single-Supply Analog Supply Filter

## Analog Outputs

The DAC-8420 features buffered analog voltage outputs capable of sourcing and sinking up to 5 mA when operating from $\pm 15 \mathrm{~V}$ supplies, eliminating the need for external buffer amplifiers in most applications while maintaining specified accuracy over the rated operating conditions. The buffered outputs are simply an op amp connected as a voltage follower, and thus have output characteristics very similar to the typical operational amplifier. These amplifiers are short-circuit protected. The designer should verify that the output load meets the capabilities of the device, in terms of both output current and load capacitance. The DAC-8420 is stable with capacitive loads up to 2 nF typical. However, any capacitive load will increase the settling time, and should be minimized if speed is a concern.
The output stage includes a p-channel MOSFET to pull the output voltage down to the negative supply. This is very important in single supply systems, where VREFLO usually has the same potential as the negative supply. With no load, the zero-scale output voltage in these applications will be less than $500 \mu \mathrm{~V}$ typically, or less than 1 LSB when $\mathrm{V}_{\text {VREFHI }}=2.5 \mathrm{~V}$. However, when sinking current this voltage does increase because of the finite impedance of the output stage. The effective value of the pull-down resistor in the output stage is typically $320 \Omega$. With a $100 \mathrm{k} \Omega$ resistor connected to +5 V , the resulting zero-scale output voltage is 16 mV . Thus, the best single supply operation is obtained with the output load connected to ground, so the output stage does not have to sink current.

Like all amplifiers, the DAC- 8420 output buffers do generate voltage noise, $52 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ typically. This is easily reduced by adding a simple RC low-pass filter on each output.

## Reference Configuration

The two reference inputs of the DAC-8420 allow a great deal of flexibility in circuit design. The user must take care, however, to observe the minimum voltage input levels on VREFHI and VREFLO to maintain the accuracy shown in the data sheet. These input voltages can be set anywhere across a wide range within the supplies, but must be a minimum of 2.5 V apart in any case. See Figure 1. A wide output voltage range can be obtained with $\pm 5 \mathrm{~V}$ references, which can be provided by the AD588 as shown in Figure 28. Many applications utilize the DACs to synthesize symmetric bipolar wave forms, which
requires an accurate, low drift bipolar reference. The AD588 provides both voltages and needs no external components. Additionally, the part is trimmed in production for 12-bit accuracy over the full temperature range without user calibration. Performing a Clear with the reset select CLSEL HIGH allows the user to easily reset the DAC outputs to midscale, or zero volts in these applications.
When driving the reference inputs VREFHI and VREFLO, it is important to note that VREFHI both sinks and sources current, and that the input currents of both are code dependent. Many voltage reference products have limited current sinking capability and must be buffered with an amplifier to drive VREFHI, in order to maintain overall system accuracy. The input VREFLO, however, has no such requirement.


Figure 28. $\pm 10$ V Bipolar Reference Configuration Using the AD588

For a single 5 V supply, $\mathrm{V}_{\text {VREFHI }}$ is limited to at most 2.5 V , and must always be at least 2.5 V less than the positive supply to ensure linearity of the device. For these applications, the REF-43 is an excellent low drift 2.5 V reference that consumes only $450 \mu \mathrm{~A}$ (max). It works well with the DAC-8420 in a single 5 V system as shown in Figure 29.


Figure 29. +5 V Single Supply Operation Using REF-43

## Isolated Digital Interface

Because the DAC-8420 is ideal for generating accurate voltages in process control and industrial applications, due to noise, safety requirements, or distance, it may be necessary to isolate it from the central controller. This can be easily achieved by using opto-isolators, which are commonly used to provide electrical isolation in excess of 3 kV . Figure 30 shows a simple 3 -wire interface scheme to control the clock, data, and load pulse. For normal operation, $\overline{\mathrm{CS}}$ is tied permanently LOW so that the DAC-8420 is always selected. The resistor and capacitor on the $\overline{\mathrm{CLR}}$ pin provide a power-on reset with 10 ms time constant. The three opto-isolators are used for the SDI, CLK, and LD lines.

One opto-isolated line ( $\overline{\mathrm{LD}}$ ) can be eliminated from this circuit by adding an inexpensive 4 -bit TTL Counter to generate the Load pulse for the DAC-8420 after 16 clock cycles. The counter is used to count of the number of clock cycles loading serial data to the DAC-8420. After all 16 bits have been clocked into the converter, the counter resets, and a load pulse is generated on clock 17. In either circuit, the DAC-8420's serial interface provides a simple, low cost method of isolating the digital control.


Figure 30. Opto-Isolated 3-Wire Interface

## Dual Window Comparator

Often a comparator is needed to signal an out-of-range warning. Combining the DAC-8420 with a quad comparator such as the CMP-04 provides a simple dual window comparator with adjustable trip points as shown in Figure 31. This circuit can be operated with either a dual or a single supply. For the A input channel, DAC B sets the low trip point and DAC A sets the upper trip point. The CMP-04 has open-collector outputs that are connected together in "Wired-OR" configuration to generate an out-of-range signal. For example, when VINA goes below the trip point set by DAC B, comparator C2 pulls the output down, turning the red LED on. The output can also be used as a logic signal for further processing.


Figure 31. Dual Programmable Window Comparator

## MC68HC11 Microcontroller Interfacing

Figure 32 shows a serial interface between the DAC-8420 and the MC68HC11 8-bit microcontroller. The SCK output of the 68 HCl 1 drives the CLK input of the DAC, and the MOSI port outputs the serial data to load into the SDI input of the DAC. The port lines PD5, PC0, PC1, and PC2 provide the controls to the DAC as shown.

*ADDITIONAL PINS OMITTED FOR CLARITY
Figure 32. MC68HC11 Microcontroller Interface

For correct operation, the $68 \mathrm{HCl1}$ should be configured such that its CPOL bit and CPHA bit are both set to 1 . In this configuration, serial data on MOSI of the $68 \mathrm{HCl1}$ is valid on the rising edge of the clock, which is the required timing for the DAC-8420. Data is transmitted in 8 -bit bytes (MSB first), with only eight rising clock edges occurring in the transmit cycle. To load data to the DAC-8420's input register, PC0 is taken low and held low during the entire loading cycle. The first 8 bits are shifted in address first, immediately followed by another 8 bits in the second least-significant byte to load the complete 16 -bit word. At the end of the second byte load, PC0 is then taken high. To prevent an additional advancing of the internal shift register, SCK must already be asserted before PC0 is taken high. To transfer the contents of the input shift register to the DAC register, PD5 is then taken low, asserting the $\overline{\mathrm{LD}}$ input of the DAC and completing the loading process. PD5 should return high before the next load cycle begins. The DAC-8420's $\overline{\mathrm{CLR}}$ input, controlled by the output PC1, provides an asynchronous clear function.

## DAC-8420 to M68HC11 Interface Assembly Program

* M68HCll Register Definitions

PORTC EQU \$1003 Port C control register

* "0,0,0,0;0,CLSEL, $\overline{C L R}, \overline{C S} "$

DDRC EQU $\$ 1007$ Port C data direction
PORTD EQU $\$ 1008$ Port D data register

* " $0,0, \overline{L D}, S C L K ; S D I, 0,0,0 "$

DDRD EQU $\$ 1009$ Port D data direction
SPCR EQU $\$ 1028$ SPI control register

* "SPIE,SPE,DWOM,MSTR;CPOL,CPHA,SPR1,SPR0"

SPSR EQU $\$ 1029$ SPI status register

* "SPIF,WCOL,0,MODF;0,0,0,0"

SPDR EQU \$102A SPI data register; Read-Buffer; Write-Shifter
*

* SDI RAM variables: SDI1 is encoded from 0 (Hex) to CF (Hex)
* To select: DAC A - Set SDIl to \$0X
* DAC B - Set SDIl to \$4X
* DAC C - Set SDIl to \$8X
* DAC D - Set SDIl to \$CX
* SDI2 is encoded from 00 (Hex) to FF (Hex)
* DAC requires two 8-bit loads - Address +12 bits

SDI1 EQU $\$ 00$ SDI packed byte 1 "A1,A0,0,0;MSB,DB10,DB9,DB8"
SDI2 EQU \$01 SDI packed byte 2
"DB7,DB6,DB5,DB4;DB3,DB2,DB1,DB0"

* Main Program

ORG $\$$ C000 Start of user's RAM in EVB
INIT LDS \#\$CFFF Top of C page RAM

* Initialize Port C Outputs

LDAA \#\$07 0,0,0,0;0,1,1,1

* CLSEL-Hi, $\overline{\mathrm{CLR}}-\mathrm{Hi}, \overline{\mathrm{CS}}-\mathrm{Hi}$
* To reset DAC to ZERO-SCALE, set CLSEL-Lo (\$03)
* To reset DAC to MID-SCALE, set CLSEL-Hi (\$07)

STAA PORTC Initialize Port C Outputs
LDAA \#\$07 0,0,0,0;0,1,1,1
STAA DDRC CLSEL, $\overline{\text { CLR }}$, and $\overline{C S}$ are now enabled as outputs

* Initialize Port D Outputs

LDAA \#\$30 0,0,1,1;0,0,0,0
LD-Hi,SCLK-Hi,SDI-Lo
STAA PORTD Initialize Port D Outputs
LDAA \# $\$ 38$ 0,0,1,1;1,0,0,0
STAA DDRD $\overline{\mathrm{LD}}, \mathrm{SCLK}$, and SDI are now enabled as outputs

* Initialize SPI Interface

LDAA \#\$5F
STAA SPCR SPI is Master,CPHA $=1, \mathrm{CPOL}=1, \mathrm{Clk}$ rate $=\mathrm{E} / 32$

* Call update subroutine

BSR UPDATE Xfer 28 -bit words to DAC-8420 JMP \$E000 Restart BUFFALO

* Subroutine UPDATE

UPDATE PSHX Save registers X, Y, and A PSHY PSHA

* Enter Contents of SDIl Data Register (DAC\# and 4 MSBs) LDAA \#\$80 1,0,0,0;0,0,0,0
STAA SDIl SDIl is set to $80(\mathrm{Hex})$
* Enter Contents of SDI2 Data Register LDAA \#\$00 0,0,0,0;0,0,0,0
STAA SDI2 SDI2 is set to 00 (Hex)
LDX \#SDIl Stack pointer at lst byte to send via SDI
LDY \#\$1000 Stack pointer at on-chip registers
* Clear DAC output to zero

BCLR PORTC, Y \$02 Assert $\overline{\text { CLR }}$ BSET PORTC, Y \$02 Deassert CLR

* Get DAC ready for data input BCLR PORTC, Y \$01 Assert CS
TFRLP LDAA 0, X Get a byte to transfer via SPI STAA SPDR Write SDI data reg to start xfer
WAIT LDAA SPSR Loop to wait for SPIF BPL WAIT SPIF is the MSB of SPSR
* (when SPIF is set, SPSR is negated) INX Increment counter to next byte for xfer CPX \#SDI2+1 Are we done yet? BNE TFRLP If not, xfer the second byte
* Update DAC output with contents of DAC register BCLR PORTD, Y \$20 Assert LD
BSET PORTD,Y $\$ 20$ Latch DAC register BSET PORTC,Y \$01 De-assert CS PULA When done, restore registers $\mathrm{X}, \mathrm{Y} \& \mathrm{~A}$ PULY
PULX
RTS ** Return to Main Program **


# Quad 8-Bit Voltage Out CMOS DAC Complete with Internal 10V Reference 

## DAC8426

## FEATURES

- No Adjustments Required, Total Error $\pm$ 1LSB Max Over Temperature
- Four Voltage-Output DACs on a Single Chip
- Internal 10V bandgap Reference
- Operates from Single +15V Supply
- Fast 50ns Data Load Time, All Temperatures
- Pin-for-Pin Replacement for PM-7226 and AD7226, Eliminates External Reference


## APPLICATIONS

## - Process Controls

- Multi-Channel Microprocessor Controlled:
- System Calibration
- Op Amp Offset and Gain Adjust
- Level and Threshold Setting


## GENERAL DESCRIPTION

The DAC-8426 is a complete quad voltage output D/A converter with internal reference. This product fits directly into any existing 7226 socket where the user currently has a 10 V external reference. The external reference is no longer necessary. The internal reference of the DAC-8426 is laser-trimmed to $\pm 0.4 \%$ offering a $25 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ temperature coefficient and 5 mA of external load driving capability.

The DAC-8426 contains four 8-bit voltage-output CMOS D/A converters on a single chip. A 10V output bandgap reference sets the output full-scale voltage. The circuit also includes four input latches and interface control logic.
One of the four latches, selected by the address inputs, is loaded from the 8 -bit data bus input when the write strobe is active low. All digital inputs are TTL/CMOS (5V) compatible. The on-board amplifiers can drive up to 10 mA from either a single or dual supply. The on-board reference that is always connected to the internal DACs has 5 mA available to drive external devices.

Continued

| ORDERING INFORMATION ${ }^{\dagger}$ |  |  |
| :---: | :---: | :---: |
| TOTAL |  |  |
| UNADJUSTED <br> ERROR <br> (LSB) | MIL TEMP | XIND TEMP |
| $\pm 1$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| $\pm 1$ | DAC8426AR | DAC8426ER |
| $\pm 2$ | - | DAC8426EP |
| $\pm 2$ | DAC8426BR | DAC8426FR |
| $\pm 2$ | - | DAC8426FP |
| 2 | - | DAC8426FS ${ }^{\dagger \dagger}$ |

* For devices processed in total compliance to MIL-STD-883, add 8883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.
tt For availability and burn-in information on SO and PLCC packages, contact your local sales office.


## SIMPLIFIED SCHEMATIC



This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

## GENERAL DESCRIPTION Continued

Its compact size, low power, and economical cost-per-channel, make the DAC-8426 attractive for applications requiring multiple D/A converters without sacrificing circuit-board space. System reliability is also increased due to reduced parts count.
PMI's advanced oxide-based, silicon-gate, CMOS process allows the DAC-8426's analog and digital circuitry to be manufactured on the same chip. This, coupled with PMI's highly stable thin-film R-2R resistor ladder, aids in matching and temperature tracking between DACs.

## PIN CONNECTIONS



ABSOLUTE MAXIMUM RATINGS

|  |  |
| :---: | :---: |
|  |  |
|  |  |
|  |  |
|  |  |
|  |  |
|  |  |
|  |  | Operating Temperature

Military AR/BR ......................................... $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ Extended Industrial ER/EP/FR/FP/FS ...... $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Maximum Junction Temperature .................................. $+150^{\circ} \mathrm{C}$
Storage Temperature ..................................... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 60 sec ) ......................... $+300^{\circ} \mathrm{C}$
THERMAL RESISTANCE

| PACKAGE TYPE | $\Theta_{\mathbf{1 A}}$ (Note 2) | $\boldsymbol{\Theta}_{\mathbf{j C}}$ | UNITS |
| :--- | :---: | :---: | :---: |
| 20-Pin CerDIP (R) | 70 | 7 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $20-$ Pin Plastic DIP (P) | 61 | 24 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $20-$ Pin SOL $(\mathrm{S})$ | 80 | 22 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTES:

1. Outputs may be shorted to any terminal provided the package power dissipation is not exceeded. Typical output short-circuit current to AGND is 50 mA .
2. $\Theta_{j A}$ is specified for worst case mounting conditions, i.e., $\Theta_{j A}$ is specified for device in socket for CerDIP and P-DIP packages; $\Theta_{j A}$ is specified for device soldered to printed circuit board for SOL package.
CAUTION:
3. Do not apply voltages higher than $\mathrm{V}_{\mathrm{DD}}$ or less than $\mathrm{V}_{\mathrm{SS}}$ potential on any terminal.
4. The digital control inputs are zener-protected; however, permanent damage may occur on unprotected units from high-energy electrostatic fields. Keep units in conductive foam at all times until ready to use.
5. Do not insert this device into powered sockets. Remove power before insertion or removal.
6. Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to device.

## BURN-IN CIRCUIT



## DAC8426

ELECTRICAL CHARACTERISTICS: $\quad V_{D D}=+15 \mathrm{~V} \pm 10 \%, A G N D=D G N D=0 \mathrm{~V}, \mathrm{~V}_{S S}=0 \mathrm{~V}, T_{A}=-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ applies for DAC-8426AR/BR, $T_{A}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ applies for DAC-8426ER/EP/FR/FP/FS, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS |  | MIN | DAC-8426 <br> TYP | MAX |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | UNITS

DIGITAL INPUTS

| Logic Input "0" | $\mathrm{V}_{\text {INL }}$ |  | - | - | 0.8 | v |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Logic Input "1" | $V_{\text {INH }}$ |  | 2.4 | - | - | V |
| Input Current | $\mathrm{I}_{1 \times}$ | $V_{I N}=O V$ or $V_{D D}$ | - | 0.1 | 10 | $\mu \mathrm{A}$ |
| Input Capacitance (Note 3) | $\mathrm{C}_{\text {IN }}$ |  | - | 4 | 8 | pF |

POWER SUPPLIES

| Positive Supply Current (Note 4) | $I_{\text {D }}$ |  |  | - | 6 | 14 | mA |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Negative Supply Current (Note 4) | Iss | Dual Supply | $V_{s s}=-5 \mathrm{~V}$ | - | 4 | 10 | mA |
| Power Dissipation (Note 5) | $P_{\text {DISS }}$ |  |  | - | 90 | 210 | mW |
| Power Supply Sensitivity | $\mathrm{P}_{\text {ss }}$ | $\Delta V_{D D}= \pm 5 \%$ |  | - | 0.0002 | 0.01 | \%\% |



LONG TERM DRIFT


POWER SUPPLY CURRENT


RELATIVE ACCURACY vs CODE
AT $\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C},+25^{\circ} \mathrm{C},+125^{\circ} \mathrm{C}$
(ALL SUPERIMPOSED)



Vout NOISE DENSITY vs FREQUENCY

$\operatorname{PSRR}(+)=-20 \operatorname{LOG}\left(\frac{V_{O U T}(0)}{\Delta V_{D D}}\right)$,
$V_{D D}=+15 \mathrm{~V} \pm 1 \mathrm{~V}_{\mathrm{p}} . \mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}$
$\operatorname{PSRR}(-)=-20 \operatorname{LOG}\left(\frac{V_{\text {OUT }}(0)}{\Delta V_{S S}}\right)$.
$V_{D D}=+15 V, V_{S S}=-4 V \pm 1 V_{P}$

## FEATURES

## Space Saving SO-8 or Mini-DIP Packages

Complete, Voltage Output with Internal Reference $1 \mathrm{mV} /$ Bit with 4.095 V Full Scale
Single + 5 Volt Operation
No External Components
3-Wire Serial Data Interface, 20 MHz Data Loading Rate
Low Power: 2.5 mW

## APPLICATIONS

Portable Instrumentation
Digitally Controlled Calibration
Servo Controls
Process Control Equipment
PC Peripherals

## GENERAL DESCRIPTION

The DAC-8512 is a complete serial input, 12 -bit, voltage output digital-to-analog converter designed to operate from a single +5 V supply. It contains the DAC, input shift register and latches, reference and a rail-to-rail output amplifier. Built using a CBCMOS process, these monolithic DACs offer the user low cost, and ease of use in +5 V only systems.
Coding for the DAC-8512 is natural binary with the MSB loaded first. The output op amp can swing to either rail and is set to a range of 0 V to +4.095 V -for a one-millivolt-per-bit resolution. It is capable of sinking and sourcing 5 mA . An on-chip reference is laser trimmed to provide an accurate fullscale output voltage of 4.095 V .

FUNCTIONAL BLOCK DIAGRAM


Serial interface is high speed, three-wire, DSP compatible with data in (SDI), clock (CLK) and load strobe (LD). There is also a chip-select pin for connecting multiple DACs.
A CLR input sets the output to zero scale at power on or upon user demand.
The DAC- 8512 is specified over the extended industrial $\left(-40^{\circ} \mathrm{C}\right.$ to $+85^{\circ} \mathrm{C}$ ) temperature range. DAC-8512s are available in plastic DIPs and SO-8 surface mount packages.


ELECTRICAL CHARACTERISTICS (@ $v_{D 0}=+5.0 \mathrm{~V} \pm 5 \%,-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$, unless otherwise noted)

| Parameter | Symbol | Condition |  | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| STATIC PERFORMANCE <br> Resolution <br> Relative Accuracy <br> Differential Nonlinearity <br> Zero-Scale Error Full-Scale Voltage <br> Full-Scale Tempco | N INL <br> DNL <br> $\mathrm{V}_{\text {ZSE }}$ <br> $\mathrm{V}_{\mathrm{FS}}$ $\mathrm{TCV}_{\mathrm{FS}}$ | Note 2 <br> No Missing Codes $\begin{aligned} & \text { Data }=000_{\mathbf{H}} \\ & \text { Data }=\mathrm{FFF}_{\mathbf{H}}{ }^{3} \end{aligned}$ <br> Notes 3, 4 | E Grade <br> F Grade <br> E Grade <br> F Grade | 12 <br> $-1$ <br> $-2$ <br> $-1$ <br> 4.087 <br> 4.079 | $\begin{aligned} & \pm 1 / 4 \\ & \pm 3 / 4 \\ & \pm 3 / 4 \\ & +1 / 2 \\ & 4.095 \\ & 4.095 \\ & 16 \end{aligned}$ | $\begin{aligned} & +1 \\ & +2 \\ & +1 \\ & +3 \\ & 4.103 \\ & 4.111 \end{aligned}$ | Bits <br> LSB <br> LSB <br> LSB <br> LSB <br> V <br> V <br> $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ |
| ANALOG OUTPUT <br> Output Current Load Regulation at Full Scale Capacitive Load | $\begin{aligned} & \mathrm{I}_{\text {OUT }} \\ & \mathrm{L}_{\text {REG }} \\ & \mathrm{C}_{\mathrm{L}} \end{aligned}$ | $\begin{aligned} & \text { Data }=800_{\mathrm{H}} \\ & \mathrm{R}_{\mathrm{L}}=402 \Omega \text { to } \infty, \text { Data }=800_{\mathrm{H}} \\ & \text { No Oscillation } \end{aligned}$ |  | $\pm 5$ | $\begin{aligned} & \pm 7 \\ & 1 \\ & 500 \end{aligned}$ | 3 | mA <br> LSB <br> pF |
| LOGIC INPUTS <br> Logic Input Low Voltage Logic Input High Voltage Input Leakage Current Input Capacitance | $\begin{aligned} & \mathrm{V}_{\mathrm{IL}} \\ & \mathrm{~V}_{\mathrm{IH}} \\ & \mathrm{I}_{\mathrm{IL}} \\ & \mathrm{C}_{\mathrm{IL}} \end{aligned}$ |  |  | 2.4 |  | $\begin{aligned} & 0.8 \\ & 10 \\ & 10 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mu \mathrm{~A} \\ & \mathrm{pF} \end{aligned}$ |
| INTERFACE TIMING SPECIF <br> Clock Width High <br> Clock Width Low <br> Load Pulse Width <br> Data Setup <br> Data Hold <br> Clear Pulse Width <br> Load Setup <br> Load Hold <br> Select <br> Deselect | ATIONS <br> $\mathrm{t}_{\mathrm{CH}}$ <br> $t_{C L}$ <br> $\mathrm{t}_{\text {LDW }}$ <br> $t_{\text {DS }}$ <br> $t_{\mathrm{DH}}$ <br> $t_{\text {CLRW }}$ <br> $t_{\text {LD1 }}$ <br> $t_{\text {LD2 }}$ <br> $t_{\mathrm{CSS}}$ <br> $t_{\mathrm{CSH}}$ |  |  | $\begin{aligned} & 30 \\ & 30 \\ & 20 \\ & 15 \\ & 15 \\ & 30 \\ & 15 \\ & 10 \\ & 30 \\ & 20 \end{aligned}$ | $\begin{aligned} & 10 \\ & 10 \\ & 10 \\ & 5 \\ & 20 \end{aligned}$ |  | ns <br> ns <br> ns <br> ns <br> ns <br> ns <br> ns <br> ns <br> ns <br> ns |
| AC CHARACTERISTICS ${ }^{4}$ <br> Voltage Output Settling Time DAC Glitch Digital Feedthrough | $\mathrm{t}_{\mathrm{s}}$ | To $\pm 1$ LSB of Final Value ${ }^{5}$ |  |  | $\begin{aligned} & 16 \\ & 15 \\ & 15 \end{aligned}$ |  | $\begin{aligned} & \mu \mathrm{s} \\ & \mathrm{nV} \mathrm{~s} \\ & \mathrm{nV} \mathrm{~s} \end{aligned}$ |
| SUPPLY CHARACTERISTICS <br> Positive Supply Current <br> Power Dissipation <br> Power Supply Sensitivity | $\begin{aligned} & \mathrm{I}_{\mathrm{DD}} \\ & \mathrm{P}_{\mathrm{DISS}} \\ & \mathrm{PSS} \end{aligned}$ | $\mathrm{V}_{\mathrm{IH}}=2.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0.8 \mathrm{~V}$, No Load <br> $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0 \mathrm{~V}$, No Load <br> $\mathrm{V}_{\mathrm{IH}}=2.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0.8 \mathrm{~V}$, No Load <br> $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0 \mathrm{~V}$, No Load <br> $\Delta \mathrm{V}_{\mathrm{DD}}= \pm 5 \%$ |  |  | $\begin{aligned} & 1.5 \\ & 0.5 \\ & 7.5 \\ & 2.5 \\ & 0.002 \end{aligned}$ | $\begin{aligned} & 2.5 \\ & 1 \\ & 12.5 \\ & 5 \\ & 0.004 \end{aligned}$ | mA <br> mA <br> mW <br> mW <br> \%/\% |

## NOTES

${ }^{1}$ All input control signals are specified with $\mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of $+5 \mathrm{~V})$ and timed from a voltage level of 1.6 V .
${ }^{2} 1 \mathrm{LSB}=1 \mathrm{mV}$ for 0 V to +4.095 V output range.
${ }^{3}$ Includes internal voltage reference error.
${ }^{4}$ These parameters are guaranteed by design and not subject to production testing.
${ }^{5}$ The settling time specification does not apply for negative going transitions within the last 6 LSBs of ground. Some devices exhibit double the typical settling time in this 6 LSB region.
Specifications subject to change without notice.

WAFER TEST LIMITS $\left(V_{D D}=+5.0 \mathrm{~V} \pm 5 \%, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right.$, applies to part number DAC8512GBC only, unless otherwise noted)

| Parameter | Symbol | Condition | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| STATIC PERFORMANCE |  |  |  |  |  |  |
| Relative Accuracy | INL |  | -2 | $\pm 3 / 4$ | +2 | LSB |
| Differential Nonlinearity | DNL | No Missing Codes | -1 | $\pm 0.7$ | +1 | LSB |
| Zero-Scale Error | $\mathrm{V}_{\text {ZSE }}$ | Data $=000_{\mathrm{H}}$ |  | $+1 / 2$ | +3 | LSB |
| Full-Scale Voltage | $\mathrm{V}_{\mathrm{FS}}$ | Data $=\mathrm{FFF}_{\mathbf{H}}$ | 4.085 | 4.095 | 4.105 | V |
| LOGIC INPUTS |  |  |  |  |  |  |
| Logic Input Low Voltage | $\mathrm{V}_{\text {IL }}$ |  |  |  | 0.8 | V |
| Logic Input High Voltage | $\mathrm{V}_{\mathrm{IH}}$ |  | 2.4 |  |  | V |
| Input Leakage Current | $\mathrm{I}_{\mathrm{IL}}$ |  |  |  | 10 | $\mu \mathrm{A}$ |
| SUPPLY CHARACTERISTICS |  |  |  |  |  |  |
| Positive Supply Current | $\mathrm{I}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{IH}}=2.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0.8 \mathrm{~V}$, No Load |  | 1.5 | 2.5 | mA |
|  |  | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0 \mathrm{~V}$, No Load |  | 0.5 | , | mA |
| Power Dissipation | $\mathrm{P}_{\text {DISS }}$ | $\mathrm{V}_{\mathrm{IH}}=2.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0.8 \mathrm{~V}$, No Load |  | 7.5 | 12.5 | mW |
|  |  | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0 \mathrm{~V}$, No Load |  | 2.5 | 5 | mW |
| Power Supply Sensitivity | PSS | $\Delta \mathrm{V}_{\mathrm{DD}}= \pm 5 \%$ |  | 0.002 | 0.004 | \%/\% |

## NOTE

Electrical tests are performed at wafer probe to the limits shown. Due to variations in assembly methods and normal yield loss, yield after packaging is not guaranteed for standard product dice. Consult factory to negotiate specifications based on dice lot qualifications through sample lot assembly and testing.



#### Abstract

Operating Temperature Range . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ Storage Temperature Range . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ Lead Temperature (Soldering, 10 secs) . . . . . . . . . . . $+300^{\circ} \mathrm{C}$ *Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.


## CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are inserted.

## WARNING!

 $\rightarrow \rightarrow$ ㄱivit esd sensitive device
## ORDERING GUIDE

| Model | INL (LSB) | Temperature Range | Package Description | Package Option ${ }^{\star}$ |
| :--- | :---: | :--- | :--- | :--- |
| DAC8512EP | $\pm 1$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8 -Pin P-DIP | N-8 |
| DAC8512FP | $\pm 2$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8 -Pin P-DIP | N-8 |
| DAC8512FS | $\pm 2$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8 -Lead SOIC | SO-8 |
| DAC8512GBC | $\pm 2$ | $+25^{\circ} \mathrm{C}$ | Dice |  |

[^63]

Figure 1. Timing Diagram


Figure 2. Equivalent Clock Input Logic

Table I. Control-Logic Truth Table

| $\overline{\mathbf{C S}^{\mathbf{2}}}$ | $\mathbf{C L K}^{\mathbf{2}}$ | $\overline{\mathbf{C L R}}$ | $\overline{\mathbf{L D}}$ | Serial Shift Register Function | DAC Register Function |
| :--- | :--- | :--- | :--- | :--- | :--- |
| $\mathbf{H}$ | $\mathbf{X}$ | $\mathbf{H}$ | $\mathbf{H}$ | No Effect | Latched |
| $\mathbf{L}$ | L | H | H | No Effect | Latched |
| L | H | H | H | No Effect | Latched |
| $\mathbf{L}$ | $\uparrow+$ | H | H | Shift-Register-Data Advanced One Bit | Latched |
| $\uparrow+$ | L | H | H | Shift-Register-Data Advanced One Bit | Latched |
| $\mathbf{H}$ | $\mathbf{X}$ | H | $\downarrow-$ | No Effect | Updated with Current Shift Register Contents |
| H | $\mathbf{X}$ | H | L | No Effect | Transparent |
| H | $\mathbf{X}$ | L | $\mathbf{X}$ | No Effect | Loaded with All Zeros |
| $\mathbf{H}$ | $\mathbf{X}$ | $\uparrow+$ | $\mathbf{H}$ | No Effect | Latched All Zeros |

[^64]PIN CONFIGURATION

SO-8


P-DIP-8


PIN DESCRIPTIONS

| Pin | Name | Description |
| :---: | :---: | :---: |
| 1 | $\mathrm{V}_{\mathrm{DD}}$ | Positive Supply. Nominal value $+5 \mathrm{~V}, \pm 5 \%$. |
| 2 | $\overline{\mathrm{CS}}$ | Chip Select. Active low input. |
| 3 | CLK | Clock input for the internal serial input shift register. |
| 4 | SDI | Serial Data Input. Data on this pin is clocked into the internal serial register on positive clock edges of the CLK pin. The Most Significant Bit (MSB) is loaded first. |
| 5 | $\overline{\mathrm{LD}}$ | Active low input which writes the serial register data into the DAC register. Asynchronous input. |
| 6 | $\overline{\text { CLR }}$ | Active low digital input that clears the DAC register to zero, setting the DAC to minimum scale. Asynchronous input. |
| 7 | GND | Analog ground for the DAC. This also serves as the digital logic ground reference voltage. |
| 8 | $\mathrm{V}_{\text {OUT }}$ | Voltage output from the DAC. Fixed output voltage range of 0 V to 4.095 V with $1 \mathrm{mV} / \mathrm{LSB}$. An internal temperature stabilized reference maintains a fixed full-scale voltage independent of time, temperature and power supply variations. |

DICE CHARACTERISTICS


SUBSTRATE IS COMMON WITH $V_{D D}$.

NUMBER OF TRANSISTORS: 642
DIE SIZE: $\mathbf{0 . 0 5 5}$ inch $\times \mathbf{0 . 1 0 6}$ inch; $\mathbf{5 8 3 0}$ sq mils

## OPERATION

The DAC- 8512 is a complete ready to use 12 -bit digital-toanalog converter. It contains a voltage-switched, 12-bit, lasertrimmed DAC, a curvature-corrected bandgap reference, a rail-to-rail output op amp, a DAC register, and a serial data input register. The serial data interface consists of a CLK, serial data in (SDI), and a load strobe ( $\overline{\mathrm{LD}}$ ). This basic 3-wire interface offers maximum flexibility for interface to the widest variety of serial data input loading requirements. In addition a $\overline{\mathrm{CS}}$ select is provided for multiple packaging loading and a power on reset $\overline{\mathrm{CLR}}$ pin to simplify start or periodic resets.

## D/A CONVERTER SECTION

The DAC is a 12 -bit voltage mode device with an output that swings from GND potential to the 2.5 volt internal bandgap voltage. It uses a laser trimmed R-2R ladder which is switched by N channel MOSFETs. The output voltage of the DAC has a constant resistance independent of digital input code. The DAC output is internally connected to the rail-to-rail output op amp.

## AMPLIFIER SECTION

The DAC's output is buffered by a low power consumption precision amplifier. This amplifier contains a differential PNP pair input stage which provides low offset voltage and low noise, as well as the ability to amplify the zero-scale DAC output voltages. The rail-to-rail amplifier is configured in a gain of 1.6384 ( $=4.095 \mathrm{~V} / 2.5 \mathrm{~V}$ ) in order to set the 4.095 volt full-scale output ( $1 \mathrm{mV} / \mathrm{LSB}$ ). See Figure 3 for an equivalent circuit schematic of the analog section.


Figure 3. Equivalent DAC-8512 Schematic of Analog Portion

The op amp has a $16 \mu \mathrm{~s}$ typical settling time to $0.01 \%$. There are slight differences in settling time for negative slewing signals vs. positive. See the oscilloscope photos in the typical performances section of this data sheet.

## OUTPUT SECTION

The rail-to-rail output stage of this amplifier has been designed to provide precision performance while operating near either power supply.


Figure 4. Equivalent Analog Output Circuit

Figure 4 shows an equivalent output schematic of the rail-to-rail amplifier with its N channel pull down FETs that will pull an output load directly to GND. The output sourcing current is provided by a $P$ channel pull up device that can supply GND terminated loads, especially at the low supply tolerance values of 4.75 volts. Figures 5 and 6 provide information on output swing performance near ground and full-scale as a function of load. In addition to resistive load driving capability the amplifier has also been carefully designed and characterized for up to 500 pF capacitive load driving capability.

## POWER SUPPLY

The very low power consumption of the DAC-8512 is a direct result of a circuit design optimizing use of the CBCMOS process. By using the low power characteristics of the CMOS for the logic, and the low noise, tight matching of the complementary bipolar transistors good analog accuracy is achieved.
For power consumption sensitive applications it is important to note that the internal power consumption of the DAC-8512 is strongly dependent on the actual logic input voltage levels present on the SDI, $\overline{\mathrm{CS}}, \overline{\mathrm{LD}}$, and $\overline{\mathrm{CLR}}$ pins. Since these inputs are standard CMOS logic structures they contribute static power dissipation dependent on the actual driving logic $\mathrm{V}_{\mathrm{OH}}$ and $\mathrm{V}_{\mathrm{OL}}$ voltage levels. The graph in Figure 9 shows the effect on total DAC-8512 supply current as a function of the actual value of input logic voltage. Consequently use of CMOS logic vs. TTL minimizes power dissipation in the static state. $A \mathrm{~V}_{\mathrm{IL}}=0 \mathrm{~V}$ on the SDI, $\overline{\mathrm{CS}}$ and CLR pins provides the lowest standby power dissipation of $2.5 \mathrm{~mW}(500 \mu \mathrm{~A} \times 5 \mathrm{~V})$.

As with any analog system, it is recommended that the DAC8512 power supply be bypassed on the same PC card that contains the chip. Figure 10 shows the power supply rejection versus frequency performance. This should be taken into account when using higher frequency switched mode power supplies with ripple frequencies of 100 kHz and higher.
One advantage of the rail-to-rail output amplifier used in the DAC-8512 is the wide range of usable supply voltage. The part is fully specified and tested over temperature for operation from +4.75 V to +5.25 V . If reduced linearity and source current capability near full scale can be tolerated, operation of the DAC8512 is possible down to +4.3 volts. The minimum operating supply voltage versus load current plot, in Figure 11, provides information for operation below $\mathrm{V}_{\mathrm{DD}}=+4.75 \mathrm{~V}$.

## TIMING AND CONTROL

The DAC-8512 has a separate serial input register from the 12-bit DAC register that allows preloading of a new data value into the serial register without disturbing the present DAC output voltage. After the new value is fully loaded in the serial input register it can be asynchronously transferred to the DAC register by strobing the $\overline{\mathrm{LD}}$ pin. The DAC register uses a level sensitive $\overline{\mathrm{LD}}$ strobe that should be returned high before any new data is loaded into the serial input register. At any time the contents of the DAC register can be reset to zero by strobing the $\overline{\mathrm{CLR}}$ pin which causes the DAC output voltage to go to zero volts. All of the timing requirements are detailed in Figure 1 along with the Table I Control-Logic Truth Table.


Figure 5. Output Swing vs. Load


Figure 8. Broadband Noise


Figure 11. Minimum Supply Voltage vs. Load


Figure 6. Pull-Down Voltage vs. Output Sink Current Capability


Figure 9. Supply Current vs. Logic Input Voltage


Figure 12. Midscale DAC Glitch Performance


Figure 7. Short Circuit Current


Figure 10. Power Supply Rejection vs. Frequency


Figure 13. Large Signal Settling Time


Figure 14. Rise Time Detail


Figure 17. Total Unadjusted Error Histogram


Figure 20. Output Voltage Noise vs. Frequency


Figure 15. Fall Time Detail


Figure 18. Full-Scale Voltage vs. Temperature


Figure 21. Long Term Drift Accelerated by Burn-In


Figure 16. Linearity Error vs. Digital Code


Figure 19. Zero-Scale Voltage vs. Temperature


Figure 22. Supply Current vs. Temperature

## APPLICATIONS SECTION

## Power Supplies, Bypassing, and Grounding

All precision converter products require careful application of good grounding practices to maintain full rated performance. Because the DAC-8512 has been designed for +5 V applications, it is ideal for those applications under microprocessor or microcomputer control. In these applications, digital noise is prevalent; therefore, special care must be taken to assure that its inherent precision is maintained. This means that particularly good engineering judgment should be exercised when addressing the power supply, grounding, and bypassing issues using the DAC-8512.
The power supply used for the DAC-8512 should be well filtered and regulated. The device has been completely characterized for a +5 V supply with a tolerance of $\pm 5 \%$. Since a +5 V logic supply is almost universally available, it is not recommended to connect the DAC directly to an unfiltered logic supply without careful filtering. Because it is convenient, a designer might be inclined to tap a logic circuit's supply for the DAC's supply. Unfortunately, this is not wise because fast logic with nanosecond transition edges induce high current pulses. The high transient current pulses can generate glitches hundreds of millivolts in amplitude due to wiring resistances and inductances. This high frequency noise will corrupt the analog circuits internal to the DAC and cause errors. Even though their spike noise is lower in amplitude, directly tapping the output of $\mathrm{a}+5 \mathrm{~V}$ system supply can cause errors because these supplies are of the switching regulator type that can and do generate a great deal of high frequency noise. Therefore, the DAC and any associated analog circuitry should be powered directly from the system power supply outputs using appropriate filtering. Figure 23 illustrates how a clean, analog-grade supply can be generated from a +5 V logic supply using a differential LC filter with separate power supply and return lines. With the values shown, this filter can easily handle 100 mA of load current without saturating the ferrite cores. Higher current capacity can be achieved with larger ferrite cores. For lowest noise, all electrolytic capacitors should be low ESR (Equivalent Series Resistance) type.


Figure 23. Properly Filtering a +5 V Logic Supply Can Yield A High Quality Analog Supply

In order to fit the DAC-8512 in an 8-pin package, it was necessary to use only one ground connection to the device. The ground connection of the DAC serves as the return path for supply currents as well as the reference point for the digital input thresholds. The ground connection also serves as the supply rail for the internal voltage reference and the output amplifier. Therefore, to minimize any errors, it is recommended that
the ground connection of the DAC-8512 be connected to a high quality analog ground, such as the one described above. Generous bypassing of the DAC's supply goes a long way in reducing supply line-induced errors. Local supply bypassing consisting of a $10 \mu \mathrm{~F}$ tantalum electrolytic in parallel with a $0.1 \mu \mathrm{~F}$ ceramic is recommended. The decoupling capacitors should be connected between the DAC's supply pin (Pin 1) and the analog ground (Pin 7). Figure 24 shows how the ground and bypass connections should be made to the DAC-8512.


Figure 24. Recommended Grounding and Bypassing Scheme for the DAC-8512

## Unipolar Output Operation

This is the basic mode of operation for the DAC-8512. As shown in Figure 24, the DAC-8512 has been designed to drive loads as low as $2 \mathrm{k} \Omega$ in parallel with 500 pF . The code table for this operation is shown in Table II.


Figure 25. Unipolar Output Operation
Table II. Unipolar Code Table

| Hexadecimal Number <br> in DAC Register | Decimal Number <br> in DAC Register | Analog Output <br> Voltage (V) |
| :---: | :---: | :---: |
| FFF | 4095 | +4.095 |
| 801 | 2049 | +2.049 |
| 800 | 2048 | +2.048 |
| 7FF | 2047 | +2.047 |
| 000 | 0 | 0 |

Operating the DAC-8512 on +12 V or +15 . V Supplies Only Although the DAC-8512 has been specified to operate on a single, +5 V supply, a single +5 V supply may not be available in many applications. Since the DAC-8512 consumes no more than 2.5 mA , maximum, then an integrated voltage reference, such as the REF-02, can be used as the DAC- $8512+5 \mathrm{~V}$ supply. The configuration of the circuit is shown in Figure 26. Notice that the reference's output voltage requires no trimming because of the REF-02's excellent load regulation and tight initial output voltage tolerance. Although the maximum supply current of the DAC-8512 is 2.5 mA , local bypassing of the REF-02's output with at least $0.1 \mu \mathrm{~F}$ at the DAC's voltage supply pin is recommended to prevent the DAC's internal digital circuits from affecting the DAC's internal voltage reference.


Figure 26. Operating the DAC-8512 on +12 V or +15 V Supplies Using a REF-02 Voltage Reference

## Measuring Offset Error

One of the most commonly specified end-point errors associated with real world nonideal DACs is offset error.
In most DAC testing, the offset error is measured by applying the zero-scale code and measuring the output deviation from 0 volt. There are some DACs where offset errors may be present but not observable at the zero scale because of other circuit limitations (for example, zero coinciding with single-supply ground). In these DACs, nonzero output at zero code cannot be read as the offset error. In the DAC-8512, for example, the zero-scale error is specified to be $\pm 3$ LSBs. Since zero scale coincides with zero volt, it is not possible to measure negative offset error.


SET CODE $=000_{\text {H }}$ AND MEASURE $V_{\text {OUT }}$
Figure 27. Measuring Zero-Scale or Offset Error

By adding a pull-down resistor from the output of the DAC8512 to a negative supply as shown in Figure 27, offset errors can now be read at zero code. This configuration forces the output p-channel MOSFET to source current to the negative supply thereby allowing the designer to determine in which direction the offset error appears. The value of the resistor should be such that, at zero code, current through the resistor is $200 \mu \mathrm{~A}$, maximum.

## Bipolar Output Operation

Although the DAC-8512 has been designed for single-supply operation, bipolar operation is achievable using the circuit illustrated in Figure 28. The circuit uses a single-supply, rail-to-rail OP-295 op amp and the REF-03 to generate the -2.5 V reference required to level-shift the DAC output voltage. Note that the -2.5 V reference was generated without the use of precision resistors. The circuit has been configured to provide an output voltage in the range $-5 \mathrm{~V} \leq \mathrm{V}_{\mathrm{OUT}} \leq+5 \mathrm{~V}$ and is coded in complementary offset binary. Although each DAC LSB corresponds to 1 mV , each output LSB has been scaled to 2.44 mV . Table III provides the relationship between the digital codes and output voltage.
The transfer function of the circuit is given by:

$$
V_{O}=-1 m V \times \text { Digital Code } \times \frac{R 4}{R 1}+2.5 \times \frac{R 4}{R 2}
$$

and, for the circuit values shown, becomes:

$$
V_{O}=-2.44 m V \times \text { Digital Code }+5 V
$$



Figure 28. Bipolar Output Operation

Table III. Bipolar Code Table

| Hexadecimal Number <br> in DAC Register | Decimal Number <br> in DAC Register | Analog Output <br> Voltage (V) |
| :---: | :---: | :--- |
| FFF | 4095 | -4.9976 |
| 801 | 2049 | $-2.44 \mathrm{E}-3$ |
| 800 | 2048 | 0 |
| 7 FF | 2047 | $+2.44 \mathrm{E}-3$ |
| 000 | 0 | +5 |

To maintain monotonicity and accuracy, R1, R2, and R4 should be selected to match within $0.01 \%$ and must all be of the same (preferably metal foil) type to assure temperature coefficient matching. Mismatching between R1 and R2 causes offset and gain errors while an R4 to R1 and R2 mismatch yields gain errors.
For applications that do not require high accuracy, the circuit illustrated in Figure 29 can also be used to generate a bipolar output voltage. In this circuit, only one op amp is used and no potentiometers are used for offset and gain trim. The output voltage is coded in offset binary and is given by:

$$
\begin{aligned}
& V_{O}=1 m V \times \text { Digital Code } \times\left(\frac{R 4}{R 3+R 4}\right) \times\left(1+\frac{R 2}{R 1}\right) \\
& -2.5 \times \frac{R 2}{R 1}
\end{aligned}
$$



Figure 29. Bipolar Output Operation without Trim
For the $\pm 2.5 \mathrm{~V}$ output range and the circuit values shown in the table, the transfer equation becomes:

$$
V_{O}=1.22 m V \times \text { Digital Code }-2.5 V
$$

Similarly, for the $\pm 5 \mathrm{~V}$ output range, the transfer equation becomes:

$$
V_{0}=2.44 m V \times \text { Digital Code }-5 V
$$

## Generating a Negative Supply Voltage

Some applications may require bipolar output configuration but only have a single power supply rail available. This is very common in data acquisition systems using microprocessor-based systems. In these systems, $+12 \mathrm{~V},+15 \mathrm{~V}$, and/or +5 V are only available. Shown in Figure 30 is a method of generating a negative supply voltage using one CD4049, a CMOS hex inverter, operating on +12 V or +15 V . The circuit is essentially a charge pump where two of the six are used as an oscillator. For the values shown, the frequency of oscillation is approximately 3.5 kHz and is fairly insensitive to supply voltage because R1> $2 \times$ R2. The remaining four inverters are wired in parallel for higher output current. The square wave output is level translated by C 2 to a negative-going signal, rectified using a pair of 1N4001s, and then filtered by C3. With the values shown, the charge pump will provide an output voltage of -5 V for current loadings in the range $0.5 \mathrm{~mA} \leq \mathrm{I}_{\mathrm{OUT}} \leq 10 \mathrm{~mA}$ with a +15 V supply and $0.5 \mathrm{~mA} \leq \mathrm{I}_{\text {OUT }} \leq 7 \mathrm{~mA}$ with a +12 V supply.


Figure 30. Generating a -5 V Supply When Only +12 V or +15 V Is Available

## A High-Compliance, Digitally Controlled Precision Current Source

The circuit in Figure 31 shows the DAC-8512 controlling a high-compliance precision current source using an AMP-05 instrumentation amplifier. The AMP-05's reference pin becomes the input, and the "old" inputs now monitor the voltage across a precision current sense resistor, $\mathbf{R}_{\mathrm{cs}}$. Voltage gain is set to unity, so the transfer function is given by the following equation:

$$
I_{O U T}=\frac{V_{I N}}{R_{C S}}
$$

If $R_{C s}$ equals $100 \Omega$, the output current is limited to +10 mA with a 1 V input. Therefore, each DAC LSB corresponds to $2.4 \mu \mathrm{~A}$. If a bipolar output current is required, then the circuit in Figure 28 can be modified to drive the AMP-05's reference pin with a $\pm 1 \mathrm{~V}$ input signal.
Potentiometer P1 trims the output current to zero with the input at 0 V . Fine gain adjustment can be accomplished by adjusting R1 or R2.


Figure 31. A High-Compliance, Digitally Controlled Precision Current Source

## A Single-Supply, Programmable Current Source

The circuit in Figure 32 shows how the DAC-8512 can be used with an OP-295 single-supply, rail-to-rail output op amp to provide a digitally programmable current sink from $\mathrm{V}_{\text {SOURCE }}$ that consumes less than 3.8 mA , maximum. The DAC's output voltage is applied across R1 by placing the 2 N 2222 transistor in the

OP-295's feedback loop. For the circuit values shown, the fullscale output current is 1 mA which is given by the following equation:

$$
I_{O U T}=\frac{D W \times 4.095 \mathrm{~V}}{R 1}
$$

where $D W=$ DAC-8512's binary digital input code.


Figure 32. A Single-Supply, Programmable Current Source
The usable output voltage range of the current sink is +5 V to +60 V . The low limit of the range is controlled by transistor saturation, and the high limit is controlled by the collector-base breakdown voltage of the 2 N 2222 .

## A Digitally Programmable Window Detector

A digitally programmable, upper/lower limit detector using two DAC-8512s is shown in Figure 33. The required upper and lower limits for the test are loaded into each DAC individually by controlling HDAC/LDAC. If a signal at the test input is not within the programmed limits, the output will indicate a logic zero which will turn the red LED on.


Figure 33. A Digitally Programmable Window Detector

## DAC8512

Opto-Isolated Interfaces for Process Control Environments
In many process control type applications, it is necessary to provide an isolation barrier between the controller and the unit being controlled. Opto-isolators can provide isolation in excess of 3 kV . The serial loading structure of the DAC- 8512 makes it ideal for optoisolated interfaces as the number of interface lines is kept to a minimum.
Illustrated in Figure 34 is an opto-isolated interface using the DAC-8512. In this circuit, the $\overline{\mathrm{CS}}$ line is always LOW to enable the DAC, and the $10 \mathrm{k} \Omega / 1 \mu \mathrm{~F}$ combination connected to the DAC's $\overline{\text { CLR }}$ pin sets a turn-on time constant of 10 ms to reset the DAC upon application of power. Three opto-couplers are then used for the SDI, SCLK, and LD lines.
Oftentimes reducing the number of interface lines to two lines is required in many control environments. The circuit illustrated in Figure 35 shows how to convert a two-line interface into the three control lines required to control the DAC-8512 without using one shots. This technique uses a counter to keep track of the clock cycles and, when all the data has been input to the DAC, the external logic generates the $\overline{\mathrm{LD}}$ pulse.


Figure 34. An Opto-Isolated DAC Interface


Figure 35. A Two-Wire, Opto-Isolated DAC Interface


Figure 36. Opto-Isolated Two-Wire Serial Interface Timing Diagram

The timing diagram of Figure 36 can be used to understand the operation of the circuit. Only two opto-couplers are used in the circuit; one for SCLK and one for SDI. The 74HC161 counter in incremented on every rising edge of the clock. Additionally, the data is loaded into the DAC-8512 on the falling edge of the clock by inverting the serial clock using gate "Y." The timing diagram shows that after the twelfth bit has been clocked the output of the counter is binary 1011. On the very next rising clock edge, the output of the counter changes to binary 1100 upon which the output of gate "X" goes LOW to generate the $\overline{\mathrm{LD}}$ pulse. The $\overline{\mathrm{LD}}$ signal is connected to both the DAC's $\overline{\mathrm{LD}}$ and the counter's LOAD pins to prevent the thirteenth rising clock edge from advancing the DAC's internal shift register. This prevents false loading of data into the DAC-8512. Inverting the DAC's serial clock allows sufficient time from the CLK edge to the $\overline{\mathrm{LD}}$ edge, and from the $\overline{\mathrm{LD}}$ edge to the next clock pulse all of which satisfies the timing requirements for loading the DAC-8512.
After loading one address of the DAC, the entire process can repeated to load another address. If the loading is complete, then the clock must stop after the thirteenth pulse of the final load. The DAC's clock input will be pulled high and the counter reset to zero. As was shown in Figure 35, both the 74HC161's and the DAC-8512's $\overline{\text { CLR }}$ pins are connected to a simple R-C timing circuit that resets both ICs when the power in turned on. The circuit's time constant should be set longer than the power supply turn-on time and, in this circuit, is set to 10 ms , which should be adequate for most systems. This same two-wire interface can be used for other three-wire serial input DACs.

## Decoding Multiple DAC-8512s

The $\overline{\mathrm{CS}}$ function of the DAC-8512 can be used in applications to decode a number of DACs. In this application, all DACs receive the same input data; however, only one of the DAC's $\overline{\mathrm{CS}}$ input is asserted to transfer its serial input register contents into the destination DAC register. In this circuit, shown in Figure 37, the $\overline{\mathrm{CS}}$ timing is generated by a 74 HCl 39 decoder and should follow the DAC-8512's standard timing requirements. To pre
vent timing errors, the 74 HCl 39 should not be activated by its ENABLE input while the coded address inputs are changing. A simple timing circuit, Rl and Cl , connected to the DACs' CLR pins resets all DAC outputs to zero during power-up.


Figure 37. Decoding Multiple DAC-8512s Using the CS Pin


Figure 38. A Digitally Controlled, Ultralow Noise VCA

## A Digitally Controlled, Ultralow Noise VCA

The circuit in Figure 38 illustrates how the DAC-8512 can be used to control an ultralow noise VCA, using the AD600/ AD602. The AD600/AD602 is a dual, low noise, wideband, variable gain amplifier based on the X-AMP topology.* Both channels of the AD600 are wired in parallel to achieve a wideband VCA which exhibits an RTI (Referred To Input) noise voltage spectral density of approximately $1 \mathrm{nV} / \sqrt{\mathrm{Hz}}$. The output of the VCA requires an AD844 configured in a gain of 4 to account for signal loss due to input and output $50-\Omega$ terminations. As configured, the total gain in the circuit is 40 dB .
Since the output of the DAC-8512 is single quadrant, it was necessary to offset the AD600's gain control voltage so that the gain of the circuit is 0 dB for zero scale and 40 dB at full scale. This was achieved by setting C1LO and C2LO to +625 mV using R1 and R2. Next, the output of the DAC-8512 was scaled so that the gain of the AD600 equalled 20 dB when the digital input code equaled $800_{\mathbf{H}}$. The frequency response of the VCA as a function of digital code is shown in Figure 39.
*For more details regarding the AD600 or AD602, please consult the AD600/ AD602 data sheet.


Figure 39. VCA Frequency Response vs. Digital Code

## A Serial DAC, Audio Volume Control

The DAC-8512 is well suited to control digitally the gain or attenuation of a voltage controlled amplifier. In professional audio mixing consoles, music synthesizers, and other audio processors, VCAs, such as the SSM-2018, adjust audio channel gain and attenuation from front panel potentiometers. The VCA provides a clean gain transition control of the audio level when the slew rate of the analog input control voltage, $\mathrm{V}_{\mathrm{C}}$, is properly chosen. The circuit in Figure 40 illustrates a volume control application using the DAC-8512 to control the attenuation of the SSM-2018.


Figure 40. A Serial DAC, Audio Volume Control
Since the supply voltage available in these systems is typically $\pm 15 \mathrm{~V}$ or $\pm 18 \mathrm{~V}$, a REF-02 is used to supply the +5 V required to power the DAC. No trimming of the reference is required because of the reference's tight initial tolerance and low supply current consumption of the DAC-8512. The SSM-2018 is configured as a unity-gain buffer when its control voltage equals 0 volt. This corresponds to a $000_{\mathbf{H}}$ code from the DAC- 8512 . Since the SSM-2018 exhibits a gain constant of $-28 \mathrm{mV} / \mathrm{dB}$ (typical), the DAC's full-scale output voltage has to be scaled down by R6 and R7 to provide 80 dB of attenuation when the digital code equals FFF $_{\mathrm{H}}$. Therefore, every DAC LSB corresponds to 0.02 dB of attenuation. Table IV illustrates the attenuation vs. digital code of the volume control circuit.

Table IV. SSM-2018 VCA Attenuation vs. DAC-8512 Input Code

| Hexadecimal Number <br> in DAC Register | Control <br> Voltage (V) | VCA <br> Attenuation (dB) |
| :--- | :--- | :--- |
| 000 | 0 | 0 |
| 400 | +0.56 | 20 |
| 800 | +1.12 | 40 |
| C00 | +1.68 | 60 |
| FFF | +2.24 | 80 |

To compensate for the SSM-2018's gain constant temperature coefficient of $-3300 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$, a $1 \mathrm{k} \Omega$, temperature-sensitive resistor (R7) manufactured by the Precision Resistor Company with a temperature coefficient of $+3500 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ is used. A $\mathrm{C}_{\mathrm{CON}}$ of $1 \mu \mathrm{~F}$ provides a control transition time of 1 ms which yields a click-free change in the audio channel attenuation. Symmetry and offset trimming details of the VCA can be found in the SSM-2018 data sheet.
Information regarding the PT146 $1 \mathrm{k} \Omega$ "Compensator" can be obtained by contacting:

> Precision Resistor Company, Incorporated
> 10601 75th Street North
> Largo, Fl 34647
> (813) $541-5771$

An Isolated, Programmable, 4-20 mA Process Controller In many process control system, applications, two-wire current transmitters are used to transmit analog signals through noisy environments. These current transmitters use a "zero-scale" signal current of 4 mA that can be used to power the transmitter's signal conditioning circuitry. The "full-scale" output signal in these transmitters is 20 mA . The converse approach to process control can also be used; a low-power, programmable current source can be used to control remotely located sensors or devices in the loop.
A circuit that performs this function is illustrated in Figure 41. Using the DAC-8512 as the controller, the circuit provides a programmable output current of 4 mA to 20 mA , proportional to the DAC's digital code. Biasing for the controller is provided by the REF-02 and requires no external trim for two reasons:
(1) the REF-02's tight initial output voltage tolerance and (2) the low supply current consumption of both the OP-90 and the DAC-8512. The entire circuit, including opto-couplers, consumes less than 3 mA from the total budget of 4 mA . The OP-90 regulates the output current to satisfy the current summation at the noninverting node of the OP-90. The KCL equation at Pin 3 is given by:

$$
I_{O U T}=\frac{1}{R 7} \times\left(\frac{1 m V \times \text { Digital Code } \times R 3}{R 1}+\frac{V_{R E F} \times R 3}{R 2}\right)
$$



Figure 41. An Isolated, Programmable, 4-20 mA Process Controller

For the values shown in Figure 41,

$$
I_{O U T}=3.9 \mu A \times \text { Digital Code }+4 m A
$$

giving a full-scale output current of 20 mA when the DAC8512 's digital code equals $\mathrm{FFF}_{\mathrm{H}}$. Offset trim at 4 mA is provided by P2, and P1 provides the circuit's gain trim at 20 mA . These two trims do not interact because the noninverting input of the OP-90 is at virtual ground. The Schottky diode, D1, is required in this circuit to prevent loop supply power-on transients from pulling the noninverting input of the OP-90 more than 300 mV below its inverting input. Without this diode, such transients could cause phase reversal of the OP-90 and possible latchup of the controller. The loop supply voltage compliance of the circuit is limited by the maximum applied input voltage to the REF-02 and is from +12 V to +40 V .

## MICROPROCESSOR INTERFACING

## DAC-8512-MC68HC11 Interface

The circuit illustrated in Figure 42 shows a serial interface between the DAC-8512 and the MC68HC11 8-bit microcontroller. SCK of the 68 HCl 11 drives SCLK of the DAC-8512, while the MOSI output drives the serial data line, SDI, of the DAC8512. The DAC's $\overline{\mathrm{CLR}}, \overline{\mathrm{LD}}$, and $\overline{\mathrm{CS}}$ signals are derived from port lines PC1, PD5, and PC0, respectively, as shown.
For correct operation of the serial interface, the $68 \mathrm{HCl1}$ should be configured such that its CPOL bit is set to 1 and its CPHA bit is also set to 1 . When the serial data is to be transmitted to the DAC, PC0 is taken low, asserting the DAC's $\overline{\mathrm{CS}}$ input. When the 68 HCl 11 is configured in this manner, serial data on


Figure 42. DAC-8512-MC68HC11 Interface
MOSI is valid on the rising edge of SCLK. The $68 \mathrm{HCl1}$ transmits its serial data in 8 -bit bytes (MSB first), with only eight rising clock edges occurring in the transmit cycle. To load data to the DAC-8512's input serial register, PC0 is left low after the first eight bits are transferred, and a second byte of data is then transferred serially to the DAC-8512. During the second byte load, the first four most significant bits of the first byte are pushed out of the DAC's input shift register. At the end of the second byte load, PC0 is then taken high. To prevent an accidental advancing of the internal shift register, SCLK must already be asserted before PC0 is taken high. To transfer the contents of the input shift register to the DAC register, PD5 is taken low, asserting the DAC's $\overline{\mathrm{LD}}$ input. The DAC's $\overline{\mathrm{CLR}}$ input, controlled by the 68HC11's PC1 port, provides an asynchronous clear function, setting the DAC output to zero. Included in this section is the source code for operating the DAC-8512-M68HC11 interface.

DAC-8512-M68HC11 Interface Program Source Code

| PORTC | EQU | \$1003 | Port C control register " $0,0,0,0 ; 0,0, \mathrm{CLR} /, \mathrm{CS} /$ " |
| :---: | :---: | :---: | :---: |
| DDRC | EQU | \$1007 | Port C data direction |
| * ${ }_{\text {* }}$ | EQU | \$1008 | Port D data register " $0,0, \mathrm{LD} /$,SCLK;SDI,0,0,0 |
| DDRD | EQU | \$1009 | Port D data direction |
| $\underset{*}{\text { SPCR }}$ | EQU | \$1028 | SPI control register <br> "SPIE,SPE,DWOM,MSTR;CPOL,CPHA,SPR1,SPR0" |
| * ${ }_{\star}$ | EQU | \$1029 | SPI status register "SPIF,WCOL,0,MODF;0,0,0,0" |
| SPDR | EQU | \$102A | SPI data register; Read-Buffer; Write-Shifter |
| * SDI RAM variables: |  |  | SDIl is encoded from 0 (Hex) to F (Hex) |
|  |  |  | SDI2 is encoded from 00 (Hex) to FF (Hex) |
|  |  |  | DAC requires two 8-bit loads; upper 4 bits of SDIl are ignored. |
|  |  |  |  |
| SDI1 | EQU | \$00 | SDI packed byte 1 " $0,0,0,0 ;$ MSB,DB10,DB9,DB8" |
| $\underset{\star}{\text { SDI2 }}$ | EQU | \$01 | SDI packed byte 2 "DB7,DB6,DB5,DB4;DB3,DB2,DB1,DB0" |
|  | ORG | \$C000 | Start of user's RAM in EVB |
| $\underset{\star}{\text { INIT }}$ | LDS | \#\$CFFF | Top of C page RAM |
|  | LDAA | \#\$03 | 0,0,0,0;0,0,1,1 |
| * |  |  | CLR/-Hi, CS/-Hi |
|  | STAA | PORTC | Initialize Port C Outputs |
|  | LDAA | \#\$03 | 0,0,0,0;0,0,1,1 |
|  | STAA | DDRC | CLR/ and CS/ are now enabled as outputs |
| * | LDAA | \#\$30 | 0,0,1,1;0,0,0,0 |
| * |  |  | LD/-Hi,SCLK-Hi,SDI-Lo |
|  | STAA | PORTD | Initialize Port D Outputs |
|  | LDAA | \#\$38 | 0,0,1,1;1,0,0,0 |
|  | STAA | DDRD | LD/,SCLK, and SDI are now enabled as outputs |
| * | LDAA | \#\$5F |  |
|  | STAA | SPCR | SPI is Master, $\mathrm{CPHA}=1, \mathrm{CPOL}=1, \mathrm{Clk}$ rate $=\mathrm{E} / 32$ |
| * | BSR | UPDATE | Xfer 28 -bit words to DAC-8512 |
|  | JMP | \$E000 | Restart BUFFALO |
| UPDATE | PSHX |  | Save registers $\mathbf{X}, \mathbf{Y}$, and A |
|  | PSHY |  |  |
|  | PSHA |  |  |
| * | LDAA | \#\$0A | 0,0,0,0;1,0,1,0 |
|  | STAA | SDII | SDIl is set to 0A (Hex) |
| * | LDAA | \#\$AA | 1,0,1,0;1,0,1,0 |
|  | STAA | SDI2 | SDI2 is set to AA (Hex) |
| * | LDX | \#SDI1 | Stack pointer at 1st byte to send via SDI |
|  | LDY | \#\$1000 | Stack pointer at on-chip registers |
| * | BCLR | PORTC, Y | \$02 Assert CLR/ |
|  | BSET | PORTC, Y | \$02 De-assert CLR/ |
|  | BCLR | PORTC,Y | \$01 Assert CS/ |


| TFRLP | LDAA STAA | $0, \mathrm{X}$ <br> SPDR | Get a byte to transfer via SPI Write SDI data reg to start xfer |
| :---: | :---: | :---: | :---: |
| WAIT | LDAA | SPSR | Loop to wait for SPIF |
|  | BPL | WAIT | SPIF is the MSB of SPSR <br> (when SPIF is set, SPSR is negated) |
|  | INX |  | Increment counter to next byte for xfer |
|  | CPX | \#SDI2+1 | Are we done yet? |
|  | BNE | TFRLP | If not, xfer the second byte |

*Update DAC output with contents of DAC register

|  | BCLR | PORTD, ${ }^{\text {Y }}$ | \$20 | Assert LD/ |
| :---: | :---: | :---: | :---: | :---: |
|  | BSET | PORTD, Y | \$20 | Latch DAC register |
|  | BSET | PORTC,Y | \$01 | De-assert CS/ |
|  | PULA When done, restore registers X, Y \& A |  |  |  |
|  | PULY |  |  |  |
|  | PULX |  |  |  |
|  | RTS |  |  | eturn to Main Progra |

FEATURES
Complete 12-Bit DAC
No External Components
Single +5 Volt Operation $1 \mathrm{mV} /$ Bit with 4.095 V Full Scale
True Voltage Output, $\pm 5 \mathrm{~mA}$ Drive
Very Low Power - 3 mW
APPLICATIONS
Digitally Controlled Calibration
Servo Controls
Process Control Equipment
PC Peripherals

## FUNCTIONAL BLOCK DIAGRAM



## GENERAL DESCRIPTION

The DAC-8562 is a complete, parallel input, 12-bit, voltage output DAC designed to operate from a single +5 volt supply. Built using a CBCMOS process, these monolithic DACs offer the user low cost, and ease-of-use in +5 volt only systems.
Included on the chip, in addition to the DAC, is a rail-to-rail amplifier, latch and reference. The reference (REFOUT) is trimmed to 2.5 volts, and the on-chip amplifier gains up the DAC output to 4.095 volts full scale. The user needs only supply a +5 volt supply.
The DAC-8562 is coded straight binary. The op amp output swings from 0 to +4.095 volts for a one millivolt per bit resolution, and is capable of driving $\pm 5 \mathrm{~mA}$. Built using low tempera-ture-coefficient silicon-chrome thin-film resistors, excellent
linearity error over temperature has been achieved as shown below in the linearity error versus digital input code plot.
Digital interface is parallel and high speed to interface to the fastest processors without wait states. The interface is very simple requiring only a single $\overline{\mathrm{CE}}$ signal. An asynchronous $\overline{\mathrm{CLR}}$ input sets the output to zero scale.
The DAC-8562 is available in two different 20-pin packages, plastic DIP and SOL-20. Each part is fully specified for operation over $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$, and the full $+5 \mathrm{~V} \pm 5 \%$ power supply range.
For MIL-STD-883 applications, contact your local ADI sales office for the DAC-8562/883 data sheet which specifies operation over the $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ temperature range.


Figure 1. Linearity Error vs. Digital Input Code Plot

## DAC8562-SPECIFICATIONS

ELECTRICAL CHARACTERISTICS
(@ $V_{D D}=+5.0 V \pm 5 \%, R_{L}=$ No Load, $-40^{\circ} \mathrm{C} \leq T_{A} \leq+85^{\circ} \mathrm{C}$, unless otherwise noted.)


## NOTES

${ }^{1}$ All input control signals are specified with $\mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of $+5 \mathrm{~V})$ and timed from a voltage level of 1.6 V .
${ }^{2} 1 \mathrm{LSB}=1 \mathrm{mV}$ for 0 to +4.095 V output range.
${ }^{3}$ Includes internal voltage reference error.
${ }^{4}$ These parameters are guaranteed by design and not subject to production testing.
${ }^{5}$ Very little sink current is available at the REFOUT pin. Use external buffer if setting up a virtual ground.
${ }^{6}$ The settling time specification does not apply for negative going transitions within the last 6 LSBs of ground. Some devices exhibit double the typical settling time in this 6 LSB region.
Specifications subject to change without notice.

WAFER TEST LIMITS
(@ $V_{D D}=+5.0 V \pm 5 \%, R_{L}=$ No Load, $T_{A}=+25^{\circ} \mathrm{C}$, applies to part number DAC8562GBC only, unless otherwise noted.)

| Parameter | Symbol | Condition | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| STATIC PERFORMANCE <br> Relative Accuracy Differential Nonlinearity Zero-Scale Error Full-Scale Voltage Reference Output Voltage | INL DNL <br> $\mathrm{V}_{\text {ZSE }}$ <br> $\mathrm{V}_{\mathrm{FS}}$ <br> $\mathrm{V}_{\text {REF }}$ | No Missing Codes <br> Data $=000_{\mathrm{H}}$ <br> Data $=\mathrm{FFF}_{\mathrm{H}}$ | $\begin{aligned} & -1 \\ & -1 \\ & 4.085 \\ & 2.490 \end{aligned}$ | $\begin{aligned} & \pm 3 / 4 \\ & \pm 3 / 4 \\ & +1 / 2 \\ & 4.095 \\ & 2.500 \end{aligned}$ | $\begin{aligned} & +1 \\ & +1 \\ & +3 \\ & 4.105 \\ & 2.510 \end{aligned}$ | $\begin{aligned} & \text { LSB } \\ & \text { LSB } \\ & \text { LSB } \\ & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |
| LOGIC INPUTS <br> Logic Input Low Voltage Logic Input High Voltage Input Leakage Current | $\begin{aligned} & \mathrm{V}_{\mathrm{IL}} \\ & \mathrm{~V}_{\mathrm{IH}} \\ & \mathrm{I}_{\mathrm{IL}} \end{aligned}$ |  | 2.4 |  | $\begin{aligned} & 0.8 \\ & 10 \end{aligned}$ | V V <br> $\mu \mathrm{A}$ |
| SUPPLY CHARACTERISTICS <br> Positive Supply Current <br> Power Dissipation <br> Power Supply Sensitivity | $I_{D D}$ <br> $P_{\text {DISS }}$ <br> PSS | $\begin{aligned} & \mathrm{V}_{\mathrm{IH}}=2.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0.8 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{IL}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=+5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{IH}}=2.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0.8 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{IL}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=+5 \mathrm{~V} \\ & \Delta \mathrm{~V}_{\mathrm{DD}}= \pm 5 \% \end{aligned}$ |  | $\begin{aligned} & 3 \\ & 0.6 \\ & 15 \\ & 3 \\ & 0.002 \end{aligned}$ | $\begin{aligned} & 6 \\ & 1 \\ & 30 \\ & 5 \\ & 0.004 \end{aligned}$ | mA <br> mA <br> mW <br> mW <br> \%/\% |

## NOTE

${ }^{1}$ Electrical tests are performed at wafer probe to the limits shown. Due to variations in assembly methods and normal yield loss, yield after packaging is not guaranteed for standard product dice. Consult factory to negotiate specifications based on dice lot qualifications through sample lot assembly and testing.

## ABSOLUTE MAXIMUM RATINGS*

$\mathrm{V}_{\mathrm{DD}}$ to DGND and AGND . . . . . . . . . . . . . $-0.3 \mathrm{~V},+10 \mathrm{~V}$
Logic Inputs to DGND . . . . . . . . . . $-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
$\mathrm{V}_{\text {OUt }}$ to AGND . . . . . . . . . . . . . . . $-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
$\mathrm{V}_{\text {REFOUT }}$ to AGND . . . . . . . . . . . $-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
AGND to DGND . . . . . . . . . . . . . . . . . . . $-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}$
I $_{\text {Out }}$ Short Circuit to GND . . . . . . . . . . . . . . . . . . . 50 mA
Package Power Dissipation . . . . . . . . . . . . $\left(\mathrm{T}_{\mathrm{J}} \max -\mathrm{T}_{\mathrm{A}}\right) / \theta_{\mathrm{JA}}$
Thermal Resistance $\theta_{\mathrm{JA}}$
20-Pin Plastic DIP Package (P) . . . . . . . . . . . . . . $74^{\circ} \mathrm{C} / \mathrm{W}$
20-Lead SOIC Package (S) . . . . . . . . . . . . . . . . . $89^{\circ} \mathrm{C} / \mathrm{W}$
Maximum Junction Temperature ( $\mathrm{T}_{\mathrm{J}} \max$ ) . . . . . . . . . . $150^{\circ} \mathrm{C}$
Operating Temperature Range . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range . ... . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 secs) . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.


Figure 2. Timing Diagram
Table I. Control Logic Truth Table

| $\overline{\mathbf{C E}}$ | $\overline{\mathbf{C L R}}$ | $\therefore$ DAC Register Function |
| :--- | :--- | :--- |
| H | H | Latched |
| L | H | Transparent |
| $\uparrow+$ | H | Latched with New Data |
| X | L | Loaded with All Zeros |
| H | $\uparrow+$ | Latched All Zeros |

$\uparrow+$ Positive Logic Transition; X Don't Care.

## CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are inserted.


*For outline information see Package Information section.

[^65]Table II. Nominal Output Voltage vs. Input Code

| Binary | Hex | Decimal | Output (V) |  |
| :--- | :--- | :--- | :--- | :--- |
| 000000000000 | 000 | 0 | $0.000 \quad$ Zero Scale |  |
| 000000000001 | 001 | 1 | 0.001 |  |
| 000000000010 | 002 | 2 | 0.002 |  |
| 000000001111 | 00 F | 15 | 0.015 |  |
| 000000010000 | 010 | 16 | 0.016 |  |
| 000011111111 | 0 FF | 255 | 0.255 |  |
| 000100000000 | 100 | 256 | 0.256 |  |
| 000111111111 | 1FF | 511 | 0.511 |  |
| 001000000000 | 200 | 512 | 0.512 |  |
| 001111111111 | 3FF | 1023 | 1.023 |  |
| 010000000000 | 400 | 1024 | 1.024 |  |
| 011111111111 | 7 FF | 2047 | 2.047 |  |
| 100000000000 | 800 | 2048 | 2.048 | Half Scale |
| 110000000000 | C00 | 3072 | 3.072 |  |
| 111111111111 | FFF | 4095 | 4.095 | Full Scale |

PIN DESCRIPTIONS

| Pin | Name | Description |
| :---: | :---: | :---: |
| 20 | $\mathrm{V}_{\text {DD }}$ | Positive supply. Nominal value +5 volts, $\pm 5 \%$. |
| $\begin{aligned} & 1-9 \\ & 17-19 \end{aligned}$ | DB0-DB11 | Twelve Binary Data Bit inputs. DB11 is the MSB and DB0 is the LSB. |
| 16 | $\overline{\mathrm{CE}}$ | Chip Enable. Active low input. |
| 15 | $\overline{\text { CLR }}$ | Active low digital input that clears the DAC register to zero, setting the DAC to minimum scale. |
| 8 | DGND | Digital ground for input logic. |
| 12 | AGND | Analog Ground. Ground reference for the internal bandgap reference voltage, the DAC, and the output buffer. |
| 13 | $\mathrm{V}_{\text {OUT }}$ | Voltage output from the DAC. Fixed output voltage range of 0 V to 4.095 V with $1 \mathrm{mV} / \mathrm{LSB}$. An internal temperature stabilized reference maintains a fixed full-scale voltage independent of time, temperature and power supply variations. |
| 14 | REFOUT | Nominal 2.5 V reference output voltage. This node must be buffered if required to drive external loads. |
| 11 | NC | No Connection. Leave pin floating. |

## OPERATION

The DAC-8562 is a complete ready to use 12 -bit digital-toanalog converter. Only one +5 V power supply is necessary for operation. It contains a voltage-switched, 12 -bit, laser-trimmed digital-to-analog converter, a curvature-corrected bandgap reference, a rail-to-rail output op amp, and a DAC register. The parallel data interface consists of 12 data bits, DB0-DB11, and a active low $\overline{\mathrm{CE}}$ strobe. In addition, an asynchronous $\overline{\mathrm{CLR}}$ pin will set all DAC register bits to zero causing the $\mathrm{V}_{\text {Out }}$ to become zero volts. This function is useful for power on reset or system failure recovery to a known state.

## D/A CONVERTER SECTION

The internal DAC is a 12 -bit voltage-mode device with an output that swings from AGND potential to the 2.5 volt internal bandgap voltage. It uses a laser trimmed R-2R ladder which is switched by N channel MOSFETs. The output voltage of the DAC has a constant resistance independent of digital input code. The DAC output (not available to the user) is internally connected to the rail-to-rail output op amp.

## AMPLIFIER SECTION

The internal DAC's output is buffered by a low power consumption precision amplifier. This low power amplifier contains a differential PNP pair input stage which provides low offset voltage and low noise, as well as the ability to amplify the zeroscale DAC output voltages. The rail-to-rail amplifier is configured in a gain of $1.6384(=4.095 \mathrm{~V} / 2.5 \mathrm{~V})$ in order to set the 4.095 volt full-scale output ( $1 \mathrm{mV} / \mathrm{LSB}$ ). See Figure 3 for an equivalent circuit schematic of the analog section.


Figure 3. Equivalent DAC-8562 Schematic of Analog Portion

The op amp has a $16 \mu$ s typical settling time to $0.01 \%$. There are slight differences in settling time for negative slewing signals versus positive. See the oscilloscope photos in the Typical Performances section of this data sheet.

## OUTPUT SECTION

The rail-to-rail output stage of this amplifier has been designed to provide precision performance while operating near either power supply. Figure 4 shows an equivalent output schematic of the rail-to-rail amplifier with its N channel pull down FETs that
will pull an output load directly to GND. The output sourcing current is provided by a $P$ channel pull-up device that can supply GND terminated loads, especially important at the $-5 \%$ supply tolerance value of 4.75 volts.


Figure 4. Equivalent Analog Output Circuit
Figures 5 and 6 in the typical performance characteristics section provide information on output swing performance near ground and full scale as a function of load. In addition to resistive load driving capability, the amplifier has also been carefully designed and characterized for up to 500 pF capacitive load driving capability.

## REFERENCE SECTION

The internal 2.5 V curvature-corrected bandgap voltage reference is laser trimmed for both initial accuracy and low temperature coefficient. The voltage generated by the reference is available at the REFOUT pin. Since REFOUT is not intended to drive external loads, it must be buffered-refer to the applications section for more information. The equivalent emitter follower output circuit of the REFOUT pin is shown in Figure 3.
Bypassing the REFOUT pin is not required for proper operation. Figure 7 shows broadband noise performance.

## POWER SUPPLY

The very low power consumption of the DAC-8562 is a direct result of a circuit design optimizing use of the CBCMOS process. By using the low power characteristics of the CMOS for the logic, and the low noise, tight matching of the complementary bipolar transistors, good analog accuracy is achieved.
For power-consumption sensitive applications it is important to note that the internal power consumption of the DAC-8562 is strongly dependent on the actual logic-input voltage-levels present on the DB0-DB11, $\overline{\mathrm{CE}}$ and $\overline{\mathrm{CLR}}$ pins. Since these inputs are standard CMOS logic structures, they contribute static power dissipation dependent on the actual driving logic $\mathrm{V}_{\mathrm{OH}}$ and $\mathrm{V}_{\mathrm{OL}}$ voltage levels. The graph in Figure 9 shows the effect on total DAC-8562 supply current as a function of the actual value of input logic voltage. Consequently for optimum dissipation use of CMOS logic versus TTL provides minimal dissipation in the static state. $\mathrm{A} \mathrm{V}_{\mathrm{INL}}=0 \mathrm{~V}$ on the DB0-DB11 pins provides the lowest standby dissipation of $600 \mu \mathrm{~A}$ with a +5 V power supply.

As with any analog system, it is recommended that the DAC8562 power supply be bypassed on the same PC card that contains the chip. Figure 10 shows the power supply rejection versus frequency performance. This should be taken into account when using higher frequency switched-mode power supplies with ripple frequencies of 100 kHz and higher.
One advantage of the rail-to-rail output amplifier used in the DAC-8562 is the wide range of usable supply voltage. The part is fully specified and tested over temperature for operation from +4.75 V to +5.25 V . If reduced linearity and source current capability near full scale can be tolerated, operation of the DAC8562 is possible down to $+4: 3$ volts. The minimum operating supply voltage versus load current plot, in Figure 11, provides information for operation below $V_{D D}=+4.75 \mathrm{~V}$.

## TIMING AND CONTROL

The DAC-8562 has a 12 -bit DAC register that simplifies inter face to a 12 -bit (or wider) data bus. The latch is controlled by the Chip Enable ( $\overline{\mathrm{CE}})$ input. If the application does not involve a data bus, wiring $\overline{\mathrm{CE}}$ low allows direct operation of the DAC.

The data latch is level triggered and acquires data from the data bus during the time period when $\overline{\mathrm{CE}}$ is low. When $\overline{\mathrm{CE}}$ goes high, the data is latched into the register and held until $\overline{\mathrm{CE}}$ returns low. The minimum time required for the data to be present on the bus before $\overline{\mathrm{CE}}$ returns high is called the data setup time ( $\mathrm{t}_{\mathrm{DS}}$ ) as seen in Figure 2. The data hold time ( $\mathrm{t}_{\mathrm{DH}}$ ) is the amount of time that the data has to remain on the bus after $\overline{\mathrm{CE}}$ goes high. The high speed timing offered by the DAC-8562 provides for direct interface with no wait states in all but the fastest microprocessors.

## Typical Performance Characteristics



Figure 5. Output Swing vs. Load


Figure 8. Broadband Noise


Figure 6. Pull-Down Voltage vs. Output Sink Current Capability


Figure 9. Supply Current vs. Logic Input Voltage


Figure 7. I IUT vs. VOUT


Figure 10. Power Supply Rejection vs. Frequency


Figure 11. Minimum Supply Voltage vs. Load


Figure 14. Output Voltage Rise Time Detail


Figure 17. Total Unadjusted Error Histogram


Figure 12. Midscale Transition Performance


Figure 15. Output Voltage Fall Time Detail


Figure 18. Full-Scale Voltage vs. Temperature


Figure 13. Large Signal Settling Time


Figure 16. Linearity Error vs. Digital Code


Figure 19. Zero-Scale Voltage vs. Temperature

## DAC8562 - Typical Performance Characteristics



Figure 20. Output Voltage Noise Density vs. Frequency


Figure 21. Long-Term Drift Accelerated by Burn-In


Figure 22. Supply Current vs. Temperature


Figure 23. Reference Startup vs. Time


Figure 24. Digital Feedthrough vs. Time


Figure 25. Reference Error vs. Temperature


Figure 26. Reference Load Regulation vs. Temperature


Figure 27. Reference Line Regulation vs. Temperature

## APPLICATIONS SECTION

## Power Supplies, Bypassing, and Grounding

All precision converter products require careful application of good grounding practices to maintain full-rated performance. Because the DAC-8562 has been designed for +5 V applications, it is ideal for those applications under microprocessor or microcomputer control. In these applications, digital noise is prevalent; therefore, special care must be taken to assure that its inherent precision is maintained. This means that particularly good engineering judgment should be exercised when addressing the power supply, grounding, and bypassing issues using the DAC-8562.
The power supply used for the DAC-8562 should be well filtered and regulated. The device has been completely characterized for a +5 V supply with a tolerance of $\pm 5 \%$. Since a +5 V logic supply is almost universally available, it is not recommended to connect the DAC directly to an unfiltered logic supply without careful filtering. Because it is convenient, a designer might be inclined to tap a logic circuit's supply for the DAC's supply. Unfortunately, this is not wise because fast logic with nanosecond transition edges induces high current pulses. The high transient current pulses can generate glitches hundreds of millivolts in amplitude due to wiring resistances and inductances. This high frequency noise will corrupt the analog circuits internal to the DAC and cause errors. Even though their spike noise is lower in amplitude, directly tapping the output of $a+5 \mathrm{~V}$ system supplies can cause errors because these supplies are of the switching regulator type that can and do generate a great deal of high frequency noise. Therefore, the DAC and any associated analog circuitry should be powered directly from the system power supply outputs using appropriate filtering. Figure 28 illustrates how a clean, analog-grade supply can be generated from $\mathrm{a}+5 \mathrm{~V}$ logic supply using a differential LC filter with separate power supply and return lines. With the values shown, this filter can easily handle 100 mA of load current without saturating the ferrite cores. Higher current capacity can be achieved with larger ferrite cores. For lowest noise, all electrolytic capacitors should be low ESR (Equivalent Series Resistance) type.


Figure 28. Properly Filtering a +5 V Logic Supply Can Yield a High Quality Analog Supply

The DAC-8562 includes two ground connections in order to minimize system accuracy degradation arising from grounding errors. The two ground pins are designated DGND (Pin 10) and AGND (Pin 12). The DGND pin is the return for the digital circuit sections of the DAC and serves as their input threshold reference point. Thus DGND should be connected to the same ground as the circuitry that drives the digital inputs.
Pin 12, AGND, serves as the supply rail for the internal voltage reference and the output amplifier. This pin should also serve as the reference point for all analog circuitry associated with the DAC-8562. Therefore, to minimize any errors, it is recommended that the AGND connection of the DAC-8562 be connected to a high quality analog ground. If the system contains any analog signal path carrying a significant amount of current, then that path should have its own return connection to Pin 12.
It is often advisable to maintain separate analog and digital grounds throughout a complete system, tying them common to one place only. If the common tie point is remote and an accidental disconnection of that one common tie point were to occur due to card removal with power on, a large differential voltage between the two commons could develop. To protect devices that interface to both digital and analog parts of the system, such as the DAC-8562, it is recommended that the common ground tie points be provided at each such device. If only one system ground can be connected directly to the DAC-8562, it recommended that the analog common be used. If the system's AGND has suitably low impedance, then the digital signal currents flowing in it should not seriously affect the ground noise. The amount of digital noise introduced by connecting the two grounds together at the device will not adversely affect system performance due to loss of digital noise immunity.
Generous bypassing of the DAC's supply goes a long way in reducing supply line-induced errors. Local supply bypassing consisting of a $10 \mu \mathrm{~F}$ tantalum electrolytic in parallel with a $0.1 \mu \mathrm{~F}$ ceramic is recommended. The decoupling capacitors should be connected between the DAC's supply pin (Pin 20) and the analog ground (Pin 12). Figure 29 shows how the DGND, AGND, and bypass connections should be made to the DAC-8562.


Figure 29. Recommended Grounding and Bypassing Scheme for the DAC-8562

## Unipolar Output Operation

This is the basic mode of operation for the DAC-8562. As shown in Figure 30, the DAC-8562 has been designed to drive loads as low as $820 \Omega$ in parallel with 500 pF . The code table for this operation is shown in Table III.


Figure 30. Unipolar Output Operation

Table III. Unipolar Code Table

| Hexadecimal Number <br> in DAC Register | Decimal Number <br> in DAC Register | Analog Output <br> Voltage (V) |
| :--- | :--- | :--- |
| FFF | 4095 | +4.095 |
| 801 | 2049 | +2.049 |
| 800 | 2048 | +2.048 |
| 7 FF | 2047 | +2.047 |
| 000 | 0 | 0 |

Operating the DAC-8562 on +12 V or +15 V Supplies Only Although the DAC-8562 has been specified to operate on a single, +5 V supply, a single +5 V supply may not be available in many applications. Since the DAC-8562 consumes no more than 6 mA , maximum, then an integrated voltage reference, such as the REF-02, can be used as the DAC- $8562+5 \mathrm{~V}$ supply. The configuration of the circuit is shown in Figure 31. Notice that the reference's output voltage requires no trimming because of the REF-02's excellent load regulation and tight initial output voltage tolerrance. Although the maximum supply current of the DAC-8562 is 6 mA , local bypassing of the REF-02's output with at least $0.1 \mu \mathrm{~F}$ at the DAC's voltage supply pin is recommended to prevent the DAC's internal digital circuits from affecting the DAC's internal voltage reference.


Figure 31. Operating the DAC-8562 on +12 V or +15 V Supplies Using a REF-02 Voltage Reference

## Measuring Offset Error

One of the most commonly specified endpoint errors associated with real-world nonideal DACs is offset error.

In most DAC testing, the offset error is measured by applying the zero-scale code and measuring the output deviation from 0 volt. There are some DACs where offset errors may be present but not observable at the zero scale because of other circuit limitations (for example, zero coinciding with single supply ground). In these DACs, nonzero output at zero code cannot be read as the offset error. In the DAC-8562, for example, the zero-scale error is specified to be +3 LSBs. Since zero scale coincides with zero volt, it is not possible to measure negative offset error.
By adding a pull-down resistor from the output of the DAC8562 to a negative supply as shown in Figure 32, offset errors can now be read at zero code. This configuration forces the output P -channel MOSFET to source current to the negative supply thereby allowing the designer to determine in which direction the offset error appears. The value of the resistor should be such that, at zero code, current through the resistor is $200 \mu \mathrm{~A}$ maximum.


Figure 32. Measuring Zero-Scale or Offset Error


## Bipolar Output Operation

Although the DAC-8562 has been designed for single supply operation, bipolar operation is achievable using the circuit illustrated in Figure 33. The circuit uses a single supply, rail-to-rail OP-295 op amp and the DAC's internal +2.5 V reference to generate the -2.5 V reference required to level-shift the DAC output voltage. The circuit has been configured to provide an output voltage in the range $-5 \mathrm{~V} \leq \mathrm{V}_{\text {OUT }} \leq+5 \mathrm{~V}$ and is coded in complementary offset binary. Although each DAC LSB corresponds to 1 mV , each output LSB has been scaled to 2.44 mV . Table IV provides the relationship between the digital codes and output voltage.
The transfer function of the circuit is given by:

$$
V_{O}=-1 m V \times \text { Digital Code } \times\left(\frac{R 4}{R 1}\right)+2.5 \times\left(\frac{R 4}{R 2}\right)
$$

and, for the circuit values shown, becomes:

$$
V_{O}=-2.44 m V \times \text { Digital Code }+5 V
$$

Table IV. Bipolar Code Table

| Hexadecimal Number <br> in DAC Register | Decimal Number <br> in DAC Register | Analog Output <br> Voltage (V) |
| :--- | :--- | :--- |
| FFF | 4095 | -4.9976 |
| 801 | 2049 | $-2.44 \mathrm{E}-3$ |
| 800 | 2048 | 0 |
| 7 FF | 2047 | $+2.44 \mathrm{E}-3$ |
| 000 | 0 | +5 |

To maintain monotonicity and accuracy, R1, R2, R4, R5, and R6 should be selected to match within $0.01 \%$ and must all be of the same (preferably metal foil) type to assure temperature coefficient matching. Mismatching between R1 and R2 causes offset and gain errors while an R4 to R1 and R2 mismatch yields gain errors.
For applications that do not require high accuracy, the circuit illustrated in Figure 34 can also be used to generate a bipolar output voltage. In this circuit, only one op amp is used and no potentiometers are used for offset and gain trim. The output
voltage is coded in offset binary and is given by:

$$
\begin{aligned}
& V_{O}=1 m V \times \text { Digital Code } \times\left(\frac{R 4}{R 3+R 4}\right) \times\left(1+\frac{R 2}{R 1}\right) \\
& -R E F O U T \times\left(\frac{R 2}{R 1}\right)
\end{aligned}
$$

For the $\pm 2.5 \mathrm{~V}$ output range and the circuit values shown in the table, the transfer equation becomes:

$$
V_{O}=1.22 m V \times \text { Digital Code }-2.5 \mathrm{~V}
$$

Similarly, for the $\pm 5 \mathrm{~V}$ output range, the transfer equation becomes:

$$
V_{O}=2.44 m V \times \text { Digital Code }-5 V
$$

Note that, for $\pm 5 \mathrm{~V}$ output voltage operation, R 5 is required as a pull-down for REFOUT. Or, REFOUT can be buffered by an op amp configured as a follower that can source and sink current.


Figure 34. Bipolar Output Operation Without Trim Version 1

Alternatively, the output voltage can be coded in complementary offset binary using the circuit in Figure 35. This configuration eliminates the need for a pull-down resistor or an op amp for

REFOUT. The transfer equation of the circuit is given by:

$$
\begin{aligned}
& V_{O}=-1 m V \times \text { Digital Code } \times\left(\frac{R 2}{R 1}\right)+\text { REFOUT } \\
& \times\left(\frac{R 4}{R 3+R 4}\right) \times\left(1+\frac{R 2}{R 1}\right)
\end{aligned}
$$

and, for the values shown, becomes:

$$
V_{O}=-2.44 m V \times \text { Digital Code }+5 V
$$



Figure 35. Bipolar Output Operation Without Trim Version 2

## Generating a Negative Supply Voltage

Some applications may require bipolar output configuration, but only have a single power supply rail available. This is very common in data acquisition systems using microprocessor-based systems. In these systems, only $+12 \mathrm{~V},+15 \mathrm{~V}$, and/or +5 V are available. Shown in Figure 36 is a method of generating a negative supply voltage using one CD4049, a CMOS hex inverter, operating on +12 V or +15 V . The circuit is essentially a charge pump where two of the six are used as an oscillator. For the values shown, the frequency of oscillation is approximately 3.5 kHz and is fairly insensitive to supply voltage because R1 $>2 \times R 2$. The remaining four inverters are wired in parallel for higher output current. The square-wave output is level translated by C2 to a negative-going signal, rectified using a pair of 1 N 4001 s , and then filtered by C3. With the values shown, the charge pump will provide an output voltage of -5 V for current loading in the range $0.5 \mathrm{~mA} \leq \mathrm{I}_{\mathrm{OUT}} \leq 10 \mathrm{~mA}$ with a +15 V supply and $0.5 \mathrm{~mA} \leq \mathrm{I}_{\text {OUT }} \leq 7 \mathrm{~mA}$ with a +12 V supply.


Figure 36. Generating a -5 V Supply When Only +12 V or +15 V Are Available

## Audio Volume Control

The DAC-8562 is well suited to control digitally the gain or attenuation of a voltage controlled amplifiers. In professional audio mixing consoles, music synthesizers, and other audio processors, VCAs, such as the SSM-2018, adjust audio channel gain
and attenuation from front panel potentiometers. The VCA provides a clean gain transition control of the audio level when the slew rate of the analog input control voltage, $\mathrm{V}_{\mathrm{C}}$, is properly chosen. The circuit in Figure 37 illustrates a volume control application using the DAC-8562 to control the attenuation of the SSM-2018.


Figure 37. Audio Volume Control
Since the supply voltage available in these systems is typically $\pm 15 \mathrm{~V}$ or $\pm 18 \mathrm{~V}$, a REF-02 is used to supply the +5 V required to power the DAC. No trimming of the reference is required because of the reference's tight initial tolerance and low supply current consumption of the DAC-8562. The SSM-2018 is configured as a unity-gain buffer when its control voltage equals 0 volt. This corresponds to a $000_{\mathrm{H}}$ code from the DAC-8562. Since the SSM-2018 exhibits a gain constant of $-28 \mathrm{mV} / \mathrm{dB}$ (typical), the DAC's full-scale output voltage has to be scaled down by R6 and R7 to provide 80 dB of attenuation when the digital code equals $\mathrm{FFF}_{\mathbf{H}}$. Therefore, every DAC LSB corresponds to 0.02 dB of attenuation. Table V illustrates the attenuation versus digital code of the volume control circuit.

Table V. SSM-2018 VCA Attenuation vs. DAC-8562 Input Code

| Hexadecimal Number <br> in DAC Register | Control Voltage <br> (V) | VCA Attenuation <br> $(\mathrm{dB})$ |
| :--- | :--- | :--- |
| 000 | 0 | 0 |
| 400 | +0.56 | 20 |
| 800 | +1.12 | 40 |
| C00 | +1.68 | 60 |
| FFF | +2.24 | 80 |

To compensate for the SSM-2018's gain constant temperature coefficient of $-3300 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$, a $1 \mathrm{k} \Omega$, temperature-sensitive resistor (R7) manufactured by the Precision Resistor Company with a temperature coefficient of $+3500 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ is used. $\mathrm{A} \mathrm{C}_{\mathrm{CON}}$ of 1 $\mu \mathrm{F}$ provides a control transition time of 1 ms which yields a click-free change in the audio channel attenuation. Symmetry and offset trimming details of the VCA can be found in the SSM-2018 data sheet.
Information regarding the PT146 $1 \mathrm{k} \Omega$ "Compensator" can be obtained by contacting:
Precision Resistor Company, Incorporated
10601 75th Street North
Largo, Fl 34647
(813) 541-5771

## A High-Compliance, Digitally Controlled Precision Current

## Source

The circuit in Figure 38 shows the DAC-8562 controlling a high-compliance, precision current source using an AMP-05 instrumentation amplifier. The AMP-05's reference pin becomes the input, and the "old" inputs now monitor the voltage across a precision current sense resistor, $\mathrm{R}_{\mathrm{Cs}}$. Voltage gain is set to unity, so the transfer function is given by the following equation:

$$
I_{O U T}=\frac{V_{I N}}{R_{C S}}
$$

If $R_{C s}$ equals $100 \Omega$, the output current is limited to +10 mA with a 1 V input. Therefore, each DAC LSB corresponds to $2.4 \mu \mathrm{~A}$. If a bipolar output current is required, then the circuit in Figure 33 can be modified to drive the AMP-05's reference pin with a $\pm 1 \mathrm{~V}$ input signal.
Potentiometer P1 trims the output current to zero with the input at 0 V . Fine gain adjustment can be accomplished by adjusting R1 or R2.

## A Digitally Programmable Window Detector

A digitally programmable, upper/lower limit detector using two DAC-8562s is shown in Figure 39. The required upper and
lower limits for the test are loaded into each DAC individually by controlling HDAC/LDAC. If a signal at the test input is not within the programmed limits, the output will indicate a logic zero which will turn the red LED on.


Figure 38. A High-Compliance, Digitally Controlled Precision Current Source


Figure 39. A Digitally Programmable Window Detector

## Decoding Multiple DAC-8562s

The $\overline{\mathrm{CE}}$ function of the DAC-8562 can be used in applications to decode a number of DACs. In this application, all DACs receive the same input data; however, only one of the DACs' $\overline{\mathrm{CE}}$ input is asserted to transfer its parallel input register contents into the DAC. In this circuit, shown in Figure 40, the $\overline{\mathrm{CE}}$ timing is generated by a $74 \mathrm{HC1} 39$ decoder and should follow the DAC-8562's standard timing requirements. To prevent timing errors, the 74 HCl 39 should not be activated by its ENABLE input while the coded address inputs are changing. A simple timing circuit, R1 and C1, connected to the DACs' $\overline{\text { CLR }}$ pins resets all DAC outputs to zero during power-up.

## MICROPROCESSOR INTERFACING

## DAC-8562-MC68HC11 Interface

The circuit illustrated in Figure 41 shows a parallel interface between the DAC-8562 and a popular 8-bit microcontroller, the $\mathrm{M} 68 \mathrm{HCl1}$, which is configured in a single-chip operating mode. The interface circuit consists of a pair of 74ACT11373 transparent latches and an inverter. The data is loaded into the latches in two 8 -bit bytes; the first byte contains the four most significant bits, and the lower 8 bits are in the second byte. Data is taken from the microcontroller's port B output lines, and three interface control lines, $\overline{\mathrm{CLR}}, \overline{\mathrm{CE}}$, and MSB/ $\overline{\mathrm{LSB}}$, are controlled by the $\mathrm{M} 68 \mathrm{HCl1}$ 's PC2, PC1, and PC0 output lines, respectively. To transfer data into the DAC, PC0 is set, enabling Ul's outputs. The first data byte is loaded into U1 where the four least significant bits of the byte are connected to MSB-DB8. PC0 is then cleared; this latches Ul's inputs and enables U2's outputs. U2s outputs now become DB7-DB0. The DAC output is updated with the contents of U 1 and U 2 when PCl is
cleared. The DAC's $\overline{\text { CLR }}$ input, controlled by the M68HCll's PC2 output line, provides an asynchronous clear function that sets the DAC's output to zero. Included in this section is the source code for operating the DAC-8562-M68HC11 interface.


Figure 40. Decoding Multiple DAC-8562s Using the $\overline{C E}$ Pin


Figure 41. DAC-8562 to MC68HC11 Interface

DAC-8562 - M68HC11 Interface Program Source Code
*

* DAC-8562 to M68HC11 Interface Assembly Program
* Adolfo A. Garcia
* September 14, 1992
* 
* M68HC11 Register definitions

PORTB EQU \$1004 PORTC EQU \$1003 *
DDRC EQU \$1007
*

* RAM variables: MSBS are encoded from 0 (Hex) to $F(H e x)$
* LSBS are encoded from 00 (Hex) to FF (Hex)
* DAC requires two 8 -bit loads

MSBS EQU $\$ 00 \quad$ Hi-byte: " $0,0,0.0 ;$ MSB,DB10,DB9,DB8" LSBS EQU \$01 Lo-byte: "DB7,DB6,DB5,DB4;DB3,DB2, DB1,DB0"
*

* Main Program

|  | ORG | $\$ C 000$ |
| :--- | :--- | :--- |
| INIT | LDS | $\# \$ C F F F$ |
| $\star$ |  |  |
| $\star$ * Initialize | Port C | Outputs |

LDAA \#\$07
STAA DDRC CLR/,CE/, and MSB-LSB/ are now enabled as outputs $0,0,0,0 ; 0,1,1,0$ CLR/-Hi, CE/-Hi, MSB-LSB/-Lo Initialize Port C Outputs

## . STAA PORTC

* Call update subroutine
* BSR UPDATE

Xfer 28 -bit words to DAC-8562 JMP \$E000

*

* Subroutine UPDATE
* 

UPDATE PSHX $\quad$ Save registers $X, Y$, and $A$
PSHY

PSHY
PSHA
*

* Enter contents of the Hi-byte input register

|  | LDAA | \#\$0A | 0,0,0,0;1,0,1,0 |
| :---: | :---: | :---: | :---: |
|  | STAA | MSBS | MSBS are set to 0A (Hex) |
| * Enter Contents of Lo-byte input register |  |  |  |
|  | LDAA | \#\$AA | 1,0,1,0;1,0,1,0 |
|  | STAA | LSBS | LSBS are set to AA (Hex) |
| $\begin{array}{lll}\text { LDX } & \text { \#MSBS } & \text { Stack pointer at lst byte to send via Port B } \\ \text { LDY } & \text { \#\$1000 } & \text { Stack pointer at on-chip registers }\end{array}$ |  |  |  |
|  |  |  |  |
| * Clear DAC output to zero |  |  |  |
|  | BCLR | PORTC, Y \$04 | Assert CLR/ |
|  | BSET | PORTC,Y \$04 | De-assert CLR/ |
| * Loading input buffer latches |  |  |  |
|  | BSET | PORTC, Y \$01 | Set hi-byte register load |
| TFRLP | LDAA | 0,X | Get a byte to transfer via Port B |
|  | STAA | PORTB | Write data to input register |
|  | INX |  | Increment counter to next byte for transfer |
|  | CPX | \#LSBS+1 | Are we done yet ? |
|  | BEQ | DUMP | If yes, update DAC output |
|  | BCLR | PORTC,Y \$01 | Latch hi-byte register and set lo-byte register load |
|  | BRA | TFRLP |  |

## DAC-8562-M68HC11 Interface Program Source Code (Continued)

* Update DAC output with contents of input registers

DUMP BCLR PORTC,Y \$02 Assert CE/ BSET PORTC, Y $\$ 02$ Latch DAC register

PULA
When done, restore registers $\mathrm{X}, \mathrm{Y} \& \mathrm{~A}$
PULY
PULX
RTS ** Return to Main Program **

Octal 8-Bit CMOS D/A Converter

## DAC8800

## FEATURES

- $\pm 1 / 2$ LSB Total Unadjusted Error
- $2 \mu \mathrm{~s}$ Settling Time
- Serial Data Input
- $\pm$ Full-Scale Output Set by $\mathbf{V}_{\text {ref }} H$ and $\mathrm{V}_{\text {fef }} \mathrm{L}$
- Unipolar and Bipolar Operation
- TTL Input Compatible
- 20-Pin DIP or SOL Package
- Low Cost


## APPLICATIONS

- Voltage Set Point Control
- Digital Offset \& Gain Adjustment
- Microprocessor Controlled Calibration
- General Purpose Trimming Adjustments


## FUNCTIONAL DIAGRAM



This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

## GENERAL DESCRIPTION

The DAC-8800 TrimDAC ${ }^{T M}$ is designed to be a general purpose digitally controlled voltage adjustment device. The output voltage range can be independently set for each set of four D/A converters. In addition, both unipolar and bipolar output voltage ranges are easy to establish by external reference input high and low terminals. The digitally-programmed output voltages are ideal for op amp trimming, voltage-controlled amplifier gain setting and any general purpose trimming tasks.

A three-wire serial digital interface loads the contents of eight internal DAC registers which establish the output voltage levels. An asynchronous Clear ( $\overline{\mathrm{CLR}}$ ) input places all DACs in a zero code output condition, very handy for system power-up. An internal regulator provides TTL input compatibility over a wide range of $V_{D D}$ supply voltages. Single supply operation is available by connecting $\mathrm{V}_{\mathrm{ss}}$ to GND .

ORDERING INFORMATION ${ }^{\dagger}$

|  | PACKAGE |  | OPERATING <br> CERDIP <br> 20-PIN |
| :---: | :---: | :---: | :---: |
| PLASTIC | SO | TEMPERATURE |  |
| DAC8800BR $^{*}$ | - | 20-PIN | RANGE |
| DAC8800FR | DAC8800FP | DAC8800FS ${ }^{+\dagger}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |

* For devices processed in total compliance to MIL-STD-883, add /883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in CerDIP and plastic DIP packages.
\#t For availability and burn-in information on SO package, contact your local sales office.


## PIN CONNECTIONS



ELECTRICAL CHARACTERISTICS: (Note 1) Unless otherwise noted, SINGLE SUPPLY: $V_{D D}=+12 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}} \mathrm{H}=+5 \mathrm{~V}$, $V_{R E F} L=O V$; or DUAL SUPPLY: $V_{D D}=+12 \mathrm{~V}, \mathrm{~V}_{S S}=-5 \mathrm{~V}, \mathrm{~V}_{\text {REF }} \mathrm{H}=+2.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}} \mathrm{L}=-2.5 \mathrm{~V}$; F GRADE: $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$; B GRADE: $-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$.

| PARAMETER | SYMBOL | CONDITIONS |  | MIN | AC-88 | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| STATIC ACCURACY All specifications apply for DACs A, B, C, D, E, F, G, H |  |  |  |  |  |  |  |
| Resolution | $N$ |  |  | 8 | - | - | Bits |
| Total Unadjusted Error (Note 2) | TUE |  |  | - | - | $\pm 1 / 2$ | LSB |
| Differential Nonlinearity (Note 3) | DNL |  |  | - | - | $\pm 1$ | LSB |
| Full Scale Error | $\mathrm{G}_{\text {FSE }}$ |  |  | - | - | $\pm 1 / 2$ | LSB |
| Zero Code Error | $V_{\text {zSE }}$ |  |  | - | - | $\pm 1 / 2$ | LSB |
| DAC Output Resistance | $\mathrm{R}_{\text {OUT }}$ |  |  | 8 | 12 | 16 | k $\Omega$ |
| DAC Output Resistance Match | $\Delta R_{\text {OUT }} / R_{\text {OUT }}$ |  |  | - | 0.5 | - | \% |
| REFERENCE INPUT |  |  |  |  |  |  |  |
| Voltage Range (Note 5) | $\mathrm{V}_{\text {REF }} \mathrm{H}$ | Pins 2 \& 19 |  | $V_{\text {REF }}{ }^{\text {L }}$ | - | $\left(N_{D D}{ }^{-4)}\right.$ | v |
|  | $V_{\text {REF }}{ }^{\text {L }}$ | Pins 1 \& 20 |  | $\mathrm{V}_{\text {ss }}$ | - | $\mathrm{V}_{\text {REF }}{ }^{\text {H }}$ |  |
| Input Resistance | $\mathrm{V}_{\text {REF }}{ }^{\text {H }}$ | Digital Inputs $=55_{\mathbf{H}}$ |  | 2 | 3 | - | k $\Omega$ |
| Input Resistance Match | $\Delta \mathrm{R}_{\text {REF }} \mathrm{H} / \mathrm{R}_{\text {REF }} \mathrm{H}$ | Digital Inputs $=55_{\mathrm{H}}$ |  | - | 0.5 | - | \% |
| Reference Input Capacitance (Note 4) | $\mathrm{C}_{\text {fef }}$ | Digital Inputs All Zeros Digital Inputs All Ones |  | - | 50 75 | $\begin{array}{r} 75 \\ 100 \end{array}$ | pF |
| DIGITALINPUTS |  |  |  |  |  |  |  |
| Logic High | $V_{\text {INH }}$ |  |  | 2.4 | - | - | v |
| Logic Low | $\mathrm{V}_{\text {INL }}$ |  |  | - | - | 0.8 | V |
| Input Current | In | $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ or |  | - | - | $\pm 1$ | $\mu \mathrm{A}$ |
| Input Capacitance (Note 4) | $\mathrm{CIN}_{\text {IN }}$ |  |  | - | 4 | 8 | pF |
| Input Coding |  |  |  | BINARY |  |  |  |
| POWER SUPPLIES (Note 6) |  |  |  |  |  |  |  |
| Positive Supply Current | IDD | Dual Supply | TTL смOS | - | 1 0.2 | $\begin{array}{r} 2 \\ 0.4 \end{array}$ | mA |
| Negative Supply Current | $\mathrm{I}_{\text {s }}$ | Dual Supply |  | - | 0.01 | 0.2 | mA |
| Power Dissipation | $P_{\text {DISs }}$ | Single Supply Operation Dual Supply Operation |  | - | 12 | $\begin{aligned} & 24 \\ & 25 \end{aligned}$ | mW |
| DC Power Supply Rejection Ratio | PSRR | $\Delta V_{D D}= \pm 5 \%$ |  | - | 0.001 | 0.01 | \%/\% |
| DYNAMIC PERFORMANCE (Note 4) |  |  |  |  |  |  |  |
| $\mathrm{V}_{\text {OUT }}$ Settling Time | $\mathrm{t}_{s}$ | $\pm 1 / 2$ LSB Err | Band | - | 0.8 | 2 | $\mu \mathrm{s}$ |
| Channel-to-Channel Crosstalk (Note 7) | CT | Measured B | een Adjacent DAC Outputs | - | 80 | - | nVs |

## DAC8800

ELECTRICAL CHARACTERISTICS: (Note 1) Unless otherwise noted, SINGLE SUPPLY: $V_{D D}=+12 V, V_{S S}=0 V, V_{R E F} H=+5 V$, $V_{R E F} L=O V$; or DUAL SUPPLY: $V_{D D}=+12 V, V_{S S}=-5 V, V_{R E F} H=+2.5 V, V_{R E F} L=-2.5 V$; F GRADE: $-40^{\circ} \mathrm{C} \leq T_{A} \leq+85^{\circ} \mathrm{C}$; B GRADE: $-55^{\circ} \mathrm{C} \leq \mathrm{T}_{A} \leq+125^{\circ} \mathrm{C}$. Continued


NOTES:

1. Testing performed in SINGLE SUPPLY mode, except $I_{D D} I_{S S}$, and PSRR which are tested in DUAL SUPPLY mode.
2. Includes Full Scale Error, Relative Accuracy, and Zero Code Error.
3. All devices guaranteed monotonic over the full operating temperature range.
4. Guaranteed by design and not subject to production test.
5. $V_{D D}-4$ volts is the maximum reference voltage for the above specifications. Also $\mathrm{V}_{\mathrm{REF}} \mathrm{H} \geqslant \mathrm{V}_{\mathrm{REF}} \mathrm{L}$.
6. Digital input voltages $V_{I N}=V_{I N L}$ or $V_{I N H}$ for TTL condition; $V_{I N}=0 \mathrm{~V}$ or +5 V for CMOS condition. DAC outputs unloaded. $P_{\text {DISS }}$ is calculated from ( $I_{D D} \times V_{D D}$ ) $+\left(l_{s s} \times V_{s s}\right)$.
7. Measured at $\mathrm{V}_{\text {OUT }}$ pin where an adjacent $\mathrm{V}_{\text {OUT }}$ pin is making a full-scale voltage change.
8. See timing diagram for location of measured values.

## DETAILED DAC-8800 BLOCK DIAGRAM



## DAC8840

## FEATURES

Replaces 8 Potentiometers
1 MHz 4-Quadrant Multiplying Bandwidth
No Signal Inversion
Low Zero Output Error
Eight Individual Channels
3-Wire Serial Input
500 kHz Update Data Loading Rate
$\pm 3$ Volt Output Swing
Midscale Preset, Zero Volts Out

## APPLICATIONS

Automatic Adjustment
Trimmer Replacement
Dynamic Level Adjustment
Special Waveform Generation and Modulation

## GENERAL DESCRIPTION

The DAC-8840 provides eight general purpose digitally controlled voltage adjustment devices. The TrimDAC ${ }^{\circledR}$ capability allows replacement of the mechanical trimmer function in new designs. The DAC-8840 is ideal for ac or dc gain control of up to 1 MHz bandwidth signals. The 4 -quadrant multiplying capability is useful for signal inversion and modulation often found in video convergence circuitry.
Internally the DAC-8840 contains eight voltage output CMOS digital-to-analog converters, each with separate reference inputs. Each DAC has its own DAC register which holds its output state. These DAC registers are updated from an internal serial-to-parallel shift register which is loaded from a standard 3-wire serial input digital interface. Twelve data bits make up the data word clocked into the serial input register. This data word is decoded where the first 4 bits determine the address of the DAC register to be loaded with the last 8 bits of data. A serial data output pin at the opposite end of the serial register allows simple daisy-chaining in multiple DAC applications without additional external decoding logic.

TrimDAC is a registered trademark of Analog Devices, Inc.

The DAC- 8840 consumes only 190 mW from $\pm 5 \mathrm{~V}$ power supplies. For single 5 V supply applications consult the DAC-8841. The DAC-8840 is available in 24 -pin plastic DIP, cerdip, and SOIC-24 packages.

## FUNCTIONAL BLOCK DIAGRAM



This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.


| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| STATIC ACCURACY | Ther | All Specifications Apply for DACs A, B, C, D, E, F, G, H |  |  |  |  |
| Resolution | N |  | 8 |  |  | Bits |
| Integral Nonlinearity | INL |  |  | $\pm 1 / 4$ | $\pm 1$ | LSB |
| Differential Nonlinearity | DNL | All Devices Monotonic |  |  | $\pm 1$ | LSB |
| Output Offset | $\mathrm{V}_{\text {BZE }}$ | $\overline{\overline{P R}}=0$, Sets $\mathrm{D}=80_{\mathrm{H}}$ |  |  | 25 | mV |
| Output Offset Drift | $\mathrm{TCV}_{B Z}$ | $\overline{\mathrm{PR}}=0$, Sets $\mathrm{D}=80_{\mathrm{H}}$ |  | 10 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| REFERENCE INPUTS |  | Applies to All Inputs $\mathrm{V}_{\text {IN }} \mathrm{X}$ |  |  |  |  |
| Voltage Range | IVR | Note 1 | $\pm 3$ |  |  | V |
| Input Resistance | $\mathrm{R}_{\text {IN }}$ | $\mathrm{D}=2 \mathrm{~B}_{\mathrm{H}}$, Code Dependent |  | 6 |  | $\mathrm{k} \Omega$ |
| Input Capacitance | $\mathrm{C}_{\text {IN }}$ | $\mathrm{D}=\mathrm{FF}_{\mathrm{H}}$, Code Dependent |  | 19 | 30 | pF |
| DAC OUTPUTS |  | Applies to All Outputs $\mathrm{V}_{\text {Out }} \mathrm{X}$ |  |  |  |  |
| Voltage Range | OVR | $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ | $\pm 3$ |  |  | V |
| Output Current | $\mathrm{I}_{\text {OUT }}$ | $\Delta \mathrm{V}_{\text {OUT }}<1$ LSB | $\pm 5$ | $\pm 10$ |  | mA |
| Capacitive Load | $\mathrm{C}_{\mathrm{L}}$ | No Oscillation |  |  | 200 | pF |
| DYNAMIC PERFORMANCE |  | Applies to All DACs |  |  |  |  |
| Multiplying Gain Bandwidth | GBW | $\mathrm{V}_{\text {IN }} \mathrm{X}=100 \mathrm{mV}$ p-p |  | 2.5 |  | MHz |
| Slew Rate |  | Measured 10\% to 90\% |  |  |  |  |
| Positive | SR+ | $\therefore \Delta \mathrm{V}_{\text {OUT }} \mathrm{X}=+6 \mathrm{~V}$ | 1.3 | 4.0 |  | $\mathrm{V} / \mu \mathrm{s}$ |
| Negative | SR-. | $\Delta \mathrm{V}_{\text {OUT }} \mathrm{X}=-6 \mathrm{~V}$ | 1.3 | 2.5 |  | V/us |
| Total Harmonic Distortion | THD | $\begin{gathered} V_{\text {IN }} X=4 V \mathrm{p}-\mathrm{p}, \mathrm{D}=\mathrm{FF}_{\mathrm{H}}, \\ \mathrm{f}=1 \mathrm{kHz}, \mathrm{f}_{\mathrm{LP}}=80 \mathrm{kHz} \end{gathered}$ |  | 0.01 |  | \% |
| Spot Noise Voltage | $\mathrm{e}_{\mathrm{N}}$ | $\mathrm{f}=1 \mathrm{kHz}$ |  | 0.17 |  | $\mu \mathrm{V} / \sqrt{\mathrm{Hz}}$ |
| Output Settling Time | $\mathbf{t s}_{\text {S }}$ | $\pm 1$ LSB Error Band, D $=0$ to $\mathrm{FF}_{\mathbf{H}}$ |  |  | 6 | $\mu \mathrm{s}$ |
| Channel-to-Channel Crosstalk |  | Measured Between Adjacent Channels, $\mathrm{f}=100 \mathrm{kHz}$ |  |  |  | dB |
| Digital Feedthrough | Q | $\mathrm{V}_{\mathrm{INX}}=0 \mathrm{~V}, \mathrm{D}=0$ to $2555_{10}$ |  | 6 |  | nVs |
| POWER SUPPLIES |  | $\overline{\text { PR }} 0 \mathrm{~V}$ |  |  |  |  |
| Power Supply Current | $\mathrm{I}_{\mathrm{DD}}$ | $\overline{\mathrm{PR}}=0 \mathrm{~V}$ |  | 19 | 26 | mA |
| Negative Supply Current | $\mathrm{I}_{\text {Ss }}$ | $\overline{\mathrm{PR}}=0 \mathrm{~V}$ |  | 19 | 26 | mA |
| Power Dissipation | $\mathrm{P}_{\text {DISS }}$ |  |  | 190 | 260 | mW |
| DC Power Supply Rejection Ratio | PSRR | $\overline{\mathrm{PR}}=0 \mathrm{~V}, \Delta \mathrm{~V}_{\mathrm{DD}}= \pm 5 \%$ |  | 0.0002 | 0.01 | \%/\% |
| Power Supply Range | PSR | $\mathrm{V}_{\mathrm{DD}},\left\|\mathrm{V}_{\text {ss }}\right\|$ | 4.75 | 5.00 | 5.25 | V |
| DIGITAL INPUTS |  | - . . . . |  |  | \% |  |
| Logic High | $\mathrm{V}_{\text {IH }}$ |  | 2.4 |  |  | V |
| Logic Low | $\mathrm{V}_{\text {IL }}$ |  |  |  | 0.8 | V |
| Input Current | $\mathrm{I}_{\mathrm{L}}$ | - |  |  | $\pm 10$ | $\mu \mathrm{A}$ |
| Input Capacitance | $\mathrm{C}_{\mathrm{IL}}$ |  |  |  | 10 | pF |
| Input Coding | . | … | Offse | inary |  |  |
| DIGITAL OUTPUT |  |  |  |  |  |  |
| Logic High | $\mathrm{V}_{\mathrm{OH}}$ | $\mathrm{I}_{\mathrm{OH}}=-0.4 \mathrm{~mA}$ | 3.5 |  |  | V |
| Logic Low | $\mathrm{V}_{\mathrm{OL}}$ | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ |  |  | 0.4 | V |

NOTE
${ }^{1}$ Maximum input voltage is always 2 V less than $\mathrm{V}_{\mathrm{DD}}$.
Specifications subject to change without notice.
TIMING SPECIFICATIONS $\begin{aligned} & \mathrm{V}_{\text {DO }}=+5 \mathrm{~V}, \mathrm{~V}_{\text {SS }}=-5 \mathrm{~V}, \text { All } \mathrm{V}_{\text {IU }} \mathrm{X}=+3 \mathrm{~V}, \mathrm{r}_{\mathrm{A}}=-40^{\circ} \mathrm{C}\end{aligned}$

| Parameter | Symbol | Min | Max | Units |
| :--- | :--- | :--- | :--- | :--- |
| Input Clock Pulse Width | $\mathrm{t}_{\mathbf{C H}}, \mathrm{t}_{\mathbf{C L}}$ | 80 |  | ns |
| Data Setup Time | $\mathrm{t}_{\mathrm{DS}}$ | 40 |  | ns |
| Data Hold Time | $\mathrm{t}_{\mathrm{DH}}$ | 20 |  | ns |
| CLK to SDO Propagation Delay | $\mathrm{t}_{\mathbf{P D}}$ |  | 120 | ns |
| DAC Register Load Pulse Width | $\mathrm{t}_{\mathrm{LD}}$ | 70 |  | ns |
| Preset Pulse Width | $\mathrm{t}_{\mathbf{P R}}$ | 50 |  | ns |
| Clock Edge to Load Time | $\mathrm{t}_{\mathbf{C K L D}}$ | 30 |  | ns |
| Load Edge to Next Clock Edge | $\mathrm{t}_{\mathbf{L D C K}}$ | 60 |  | ns |

## PIN DESCRIPTION

| PIN | MNEMONIC | DESCRIPTION |
| :---: | :---: | :---: |
| 1 | $\mathbf{V}_{\text {out }} \mathbf{C}$ | DAC C Output |
| 2 | $\mathbf{V}_{\text {Out }}{ }^{\text {B }}$ | DAC B Output |
| 3 | Vout ${ }^{\text {A }}$ | DAC A Output |
| 4 | $V_{\text {IN }} \mathrm{B}$ | DAC B Reference Input |
| 5 | $V_{\text {IN }} A$ | DAC A Reference Input |
| 6 | GND | Ground |
| 7 | $\overline{\text { PR }}$ | Preset Input, Active Low, All DAC Registers $=\mathbf{8 0}_{\mathbf{H}}$ |
| 8 | $V_{\text {IN }} E$ | DAC E Reference Input |
| 9 | $V_{1 N} F$ | DAC F Reference Input |
| 10 | $V_{\text {OUT }} \mathrm{E}$ | DAC E Output |
| 11 | $V_{\text {Out }} \mathbf{F}$ | DAC F Output |
| 12 | $\mathbf{V}_{\text {Out }} \mathbf{G}$ | DAC G Output |
| 13 | $\mathrm{V}_{\text {Out }} \mathrm{H}$ | DAC H Output |
| 14 | $V_{\text {IN }} \mathrm{G}$ | DAC G Reference Input |
| 15 | $\mathrm{V}_{10} \mathrm{H}$ | DAC H Reference Input |
| 16 | LD | Load DAC Register Strobe, Active High Input That Transfers the Data Bits from the Serial Input Register into the Decoded DAC Register. See Table I. |
| 17 | CLK | Serial Clock Input, Positive Edge Triggered |
| 18 | SDO | Serial Data Output, Active Totem Pole Output |
| 19 | $\mathrm{V}_{\text {ss }}$ | Negative 5 V Power Supply |
| 20 | SDI | Serial Data Input |
| 21 | $V_{\text {DD }}$ | Positive 5 V Power Supply |
| 22 | $V_{\text {IN }}$ D | DAC D Reference Input |
| 23 | $V_{1 N}{ }^{\text {c }}$ | DAC C Reference Input |
| 24 | $V_{\text {Out }}$ D | DAC D Output |


| ABSOLUTE MAXIMUM RATINGS <br> ( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted) |  |
| :---: | :---: |
| $\mathrm{V}_{\mathrm{DD}}$ to GND | 3, +7 V |
| $\mathrm{V}_{\text {Ss }}$ to GND | +0.3, -7 V |
| $\mathrm{V}_{\text {IN }} \mathrm{X}$ to GND | $\mathrm{V}_{\mathrm{DD}}, \mathrm{V}_{\text {Ss }}$ |
| $\mathrm{V}_{\text {OuT }} \mathrm{X}$ to GND | $\mathrm{V}_{\text {DD }}, \mathrm{V}_{\text {SS }}$ |
| Short Circuit $\mathrm{I}_{\text {OuT }} \mathrm{X}$ to GND | Continuous |
| Digital Input \& Output Voltage to GND | $\mathrm{V}_{\mathrm{DD}}, \mathrm{V}_{\text {Ss }}$ |
| Operating Temperature Range |  |
| Extended Industrial: DAC8840F | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Maximum Junction Temperature ( $\mathrm{T}_{\mathrm{J}}$ max) . . . . . . . $+150^{\circ} \mathrm{C}$ |  |
| Storage Temperature . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |  |
| Lead Temperature (Soldering, 10 sec ) . . . . . . . . . $+300^{\circ} \mathrm{C}$ |  |
| Package Power Dissipation . . . . . . . . $\left(\mathrm{T}_{\mathrm{J}} \mathrm{Max}-\mathrm{T}_{\mathrm{A}}\right) / \theta_{\mathrm{JA}}$ |  |
| Thermal Resistance $\theta_{\text {JA }}$ |  |
| Cerdip | $.64{ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| P-DIP | $57^{\circ} \mathrm{C} / \mathrm{W}$ |
| SOIC-24 | $70^{\circ} \mathrm{C} / \mathrm{W}$ |

ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| DAC8840FP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Plastic DIP | $\mathrm{N}-24$ |
| DAC8840FW | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Cerdip | Q-24 |
| DAC8840FS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | SOL-24 | R-24 |
| DAC8840GBC | $25^{\circ} \mathrm{C}$ | DICE |  |

*For outline information see Package Information section.

## PIN CONFIGURATION



## DICE CHARACTERISTICS

DIE SIZE $0.117 \times 0.185$ inch, 21,645 sq. mils ( $2.9718 \times 4.699 \mathrm{~mm}, 13.964$ sq. mm )
The die backside is electrically common to $\mathrm{V}_{\mathrm{DD}}$. The DAC8840 contains 3236 transistors.

*BOTH GND PADS (6a, 6b) ARE BONDED TO PIN 6 OF PACKAGE.

## CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are inserted.


## V/F and F/N Converters

Selection Tree ..... 4-2
Selection Guides ..... 4-3
AD537 - Integrated Circuit Voltage-to-Frequency Converter ..... 4-5
AD650 - Voltage-to-Frequency and Frequency-to-Voltage Converter ..... 4-7
AD652 - Monolithic Synchronous Voltage-to-Frequency Converter ..... 4-10
AD654 - Low Cost Monolithic Voltage-to-Frequency Converter ..... 4-14

## Selection Tree - V/F and F/V Converters

## V/F AND F/V CONVERTERS

AD537 $(50 \mathrm{kHz})$
AD654 ( 500 kHz )
AD650 ( 1 MHz )

Synchronous
AD652 ( 2 MHz )

## Selection Guides - V/F and FN Converters

## Voltage-to-Frequency Converters

|  |  |  | FS |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Full-Scale | Linearity | Error |  | Input |  |  |  |  |
|  | Frequency | \% | \% | Output | Range | Package | Temp |  |  |
| Model | MHz | max | typ | Format | V | Options ${ }^{1}$ | Ranges ${ }^{2}$ | Page ${ }^{3}$ | Comments |
| AD652 | 2 | 0.005-0.05 | 0.25-0.5 | Pulse Train | 0 to 10, $\pm 5$ | $\mathbf{E}, \mathbf{P}, \mathbf{Q}$ | C, I, M/ | 4-10 | Synchronous, Multiple Input Ranges, |
|  |  |  |  |  | 0 to -10 |  |  |  | Low Linearity, Single Supply |
| AD650 | 1 | 0.005-0.1 | 5-10 | Pulse Train | 0 to 10, $\pm 5$ | D, N, P | C, I, M | 4-7 | Low Nonlinearity, Multiple Input Ranges |
|  |  |  |  |  | 0 to -10 |  |  |  |  |
| AD654 | 0.5 | 0.1-0.4 | 10 | Square Wave | 0 to ( $\mathrm{V}_{\mathrm{s}}$ ) | N, $\mathbf{R}$ | C | 4-14 | Single Supply, Low Cost |
| AD537 | 0.15 | 0.07-0.25 | 5 | Square Wave | $-V_{s}$ to ( $+V_{s}-4$ ) | D, H | C, M/ | 4-5 | Single Supply, Military Grade |

## Frequency-to-Voltage Converters

| Model | Linearity Input Range $\mathbf{k H z}$ | Response Time \% max | ms typ | Package Options ${ }^{1}$ | Temp Ranges ${ }^{2}$ | Page ${ }^{3}$ | Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 451 | 0 to 10 | 0.03-0.008 | 4 | Module | I | D | Complete, No External Components |
| 453 | 0 to 100 | 0.03-0.008 | 0.8 | Module | I | D | Complete, No External Components |
| AD650 | 0 to 1000 | 0.005-0.1 | - | D, $\mathbf{N}, \mathbf{P}$ | C, I, M/ | 4-14 | Low Nonlinearity |




 temperature designator will be followed by: / to indicate $883 \mathrm{~B},{ }_{\mathrm{J}}$ for JAN, ${ }_{\mathrm{D}}$ for SMD, and $\mathrm{S}_{\mathrm{s}}$ for space level.
${ }^{3} \mathrm{D}=$ Data Sheet. All other entries refer to this volume
Boldface Type: Data sheet information in this volume.

# Voltage-to-Frequency Converter 

## FEATURES

Low Cost A-D Conversion
Versatile Input Amplifier
Positive or Negative Voltage Modes Negative Current Mode
High Input Impedance, Low Drift
Single Supply, 5 to 36 Volts
Linearity: $\pm 0.05 \%$ FS
Low Power: 1.2mA Quiescent Current
Full Scale Frequency up to $\mathbf{1 0 0 k H z}$
1.00 Volt Reference

Thermometer Output (1mV/K)
F-V Applications
F-V Applications
MIL-STD-883 Compliant Versions Available

## PRODUCT DESCRIPTION

The AD5 37 is a monolithic V-F converter consisting of an input amplifier, a precision oscillator system, an accurate internal reference generator and a high current output stage. Only a single external RC network is required to set up any full scale (F.S.) frequency up to 100 kHz and any F.S. input voltage up to $\pm 30 \mathrm{~V}$. Linearity error is as low as $\pm 0.05 \%$ for 10 kHz F.S., and operation is guaranteed over an 80 dB dynamic range. The overall temperature coefficient (excluding the effects of external components) is typically $\pm 30 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$. The AD537 operates from a single supply of 5 to 36 V and consumes only 1.2 mA quiescent current.

A temperature-proportional output, scaled to $1.00 \mathrm{mV} / \mathrm{K}$, enables the circuit to be used as a reliable temperature-tofrequency converter; in combination with the fixed reference output of 1.00 V , offset scales such as $0^{\circ} \mathrm{C}$ or $0^{\circ} \mathrm{F}$ can be generated.
The low drift ( $1 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ typ) input amplifier allows operation directly from small signals (e.g., thermocouples or strain gages) while offering a high ( $250 \mathrm{M} \Omega$ ) input resistance. Unlike most V-F converters, the AD5 37 provides a square-wave output, and can drive up to 12 TTL loads, LEDs, very long cables, etc.
The excellent temperature characteristics and long-term stability of the AD5 37 are guaranteed by the primary band-gap reference generator and the low T.C. silicon chromium thin film resistors used throughout.
The device is available in either a TO-116 ceramic DIP or a TO-100 metal can; both are hermetically sealed packages.

## PIN CONFIGURATIONS



The AD537 is available in three performance/temperature grades; the J and $K$ grades are specified for operation over the 0 to $+70^{\circ} \mathrm{C}$ range while the AD537S is specified for operation over the extended temperature range, $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.

## PRODUCT HIGHLIGHTS

1. The AD5 37 is a complete $\mathrm{V}-\mathrm{F}$ converter requiring only an external RC timing network to set the desired full scale frequency and a selectable pull-up resistor for the opencollector output stage. Any full-scale input voltage range from 100 mV to 10 volts (or greater, depending on $+V_{S}$ ) can be accommodated by proper selection of timing resistor. The full scale frequency is then set by the timing capacitor from the simple relationship, $\mathrm{f}=\mathrm{V} / 10 \mathrm{RC}$.
2. The power supply requirements are minimal, only 1.2 mA quiescent current is drawn from a single positive supply from 4.5 to 36 volts. In this mode, positive inputs can vary from 0 volts (ground) to ( $+V_{S}-4$ ) volts. Negative inputs can easily be connected for below ground operation.
3. F-V converters with excellent characteristic are also easy to build by connecting the AD537 in a phase-locked loop. Application particulars are shown in Figure 6.
4. The versatile open-collector NPN output stage can sink up to 2.0 mA with a saturation voltage less than 0.4 volts. The Logic Common terminal can be connected to any level between ground (or $-\mathrm{V}_{\mathbf{S}}$ ) and 4 volts below $+\mathrm{V}_{\mathbf{S}}$. This allows easy direct interface to any logic family with either positive or negative logic levels.
5. The AD537 is available in versions compliant with MIL-STD883. Refer to the Analog Devices Military Product Databook or current AD537/883B data sheet for detailed specifications.
[^66][^67]| MODEL | AD537JH | AD537JD | $\begin{aligned} & \text { AD537KD } \\ & \text { AD537KH } \end{aligned}$ | $\begin{aligned} & \text { AD537SD }^{\mathbf{1}} \\ & \text { AD537SH }^{1} \end{aligned}$ |
| :---: | :---: | :---: | :---: | :---: |
| CURRENT-TO-FREQUENCY CONVERTER |  |  |  |  |
| Frequency Range | 0 to 150 kHz | * | * | * |
| Nonlinearity ${ }^{1}$ |  |  |  |  |
| $\mathrm{f}_{\text {max }}=10 \mathrm{kHz}$ | 0.15\% max (0.1\% typ) | * | 0.07\% max | ** |
| $\mathrm{f}_{\text {max }}=100 \mathrm{kHz}$ | 0.25\% max ( $0.15 \%$ typ) | * | 0.1\% max | ** |
| Full Scale Calibration Error | (2) |  |  |  |
| $C=0.01 \mu \mathrm{~F}, \mathrm{I}_{\mathbf{N}}=1.000 \mathrm{~mA}$ | $\pm 10 \%$ max | $\pm 7 \%$ max | $\pm 5 \%$ max | ** |
| vs. Supply ( $\mathrm{f}_{\max }<100 \mathrm{kHz}$ ) | $\pm 0.1 \% / V \max ^{(0.01 \% ~ t y p)}$ | * | * |  |
| vs. Temp. ( $\mathrm{T}_{\min }$ to $\mathrm{T}_{\text {max }}$ ) | $\pm 150 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ max (50ppm typ) | * | 50ppm $/{ }^{\circ} \mathrm{C} \max \left(30 \mathrm{ppm}\right.$ typ) ${ }^{2}$ | 250ppm/ ${ }^{\circ} \mathrm{C}$ max |

ANALOG INPUT AMPLIFIER
(Voltage-to-Current Converter)
Voltage Input Range
Single Supply 0 to $\left(+V_{\mathbf{S}}-4\right)$ Volts (min) * * * * * * *
Dual Supply * $\quad-V_{S}$ to $\left(+V_{S}-4\right)$ Volts (min) * * * * * * *
Input Bias Current :

| 0 to $\left(+V_{S}-4\right)$ Volts (min) <br> $-V_{S}$ to $\left(+V_{S}-4\right)$ Volts (min) | * | * |  |
| :---: | :---: | :---: | :---: |
| 100 nA | * | * | * . . . . |
| 250M $\Omega$ | * | $\cdots$ | * |
| 5 mV max | * | 2 mV max | ** |
| $200 \mu \mathrm{~V} / \mathrm{V}$ max | $100 \mu \mathrm{~V} / \mathrm{V}$ max | $100 \mu \mathrm{~V} / \mathrm{V}$ max | ** |
| $5 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ | , | $1 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ | $10 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ max |
| $\pm V_{S}$ | * | * | ${ }^{1}$ |



OUTPUT INTERFACE (Open Collector Output)
(Symmetrical Square Wave)
Output Sink Current in Logic " 0 "
$\mathrm{V}_{\text {OUT }}=0.4 \mathrm{~V}$ max, $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ )
Output Leakage Current in Logic " 1 "
( $T_{\min }$ to $T_{\text {max }}$ )
Logic Common Level Range
Rise/Fall Times ( $\mathrm{C}_{\mathrm{T}}=0.01 \mu \mathrm{~F}$ )
$\mathrm{I}_{\mathrm{IN}}=1 \mathrm{~mA}$
$I_{\mathbb{N}}=1 \mu \mathrm{~A}$

| $20 \mathrm{~mA} \min$ | $20 \mathrm{~mA} \min$ | 20 mA min | 10 mA min |
| :--- | :--- | :--- | :--- |
| $200 \mathrm{nA} \max$ | $*$ | $*$ | $\mathbf{2 \mu A}$ max |
| $-V_{S}$ to $\left(+V_{S}-4\right)$ Volts | $*$ | $*$ | $*$ |
| $0.2 \mu \mathrm{~s}$ | $*$ | $*$ | $*$ |

POWER SUPPLY

| POWER SUPPLY <br> Voltage, Rated Performance <br> Single Supply <br> Dual Supply |  |  |  |
| :--- | :--- | :--- | :--- |
| Quiescent Current |  |  |  |

## NOTES

-Specifications same as AD5 37JH.

- =Specifications same as AD537K.

Specifications subject to change without notice.
' Nonlinearity is specified for a current input level (IIN) to the converter from 0.1 to $1000 \mu \mathrm{~A}$. Converter has $100 \%$ overrange capability up to $\mathrm{I}_{\mathrm{IN}}=\mathbf{2 0 0 0} \mu \mathrm{A}$ with slightly reduced linearity. Nonlinearity is defined as deviation from a straight line from zero to full scale, expressed as a percentage of full scale.
${ }^{2}$ Guaranteed not tested.
${ }^{3}$ Maximum voltage input level is equal to the supply on either input serminal. However, large negative woltage levels can be applied to the negative terminal if the input is scaled to a nominal 1 mA full scale through an appropriate value resistor (see Figure 2).
${ }^{4}$ Loading the 1.0 volt or $1 \mathrm{mV} / \mathrm{K}$ outputs can cause a significant change in overall circuit performance, as indicated in the applications section.
To maintain normal operation, these outputs should be operated into the external buffer or an external amplifier.
${ }^{5}$ Temperature reference output performance is specified from 0 to $+70^{\circ} \mathrm{C}$ for " J " and " K " devices, $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ for " S " model.
${ }^{6}$ D = Ceramic DIP; H = Hermetic Metal Can. For outline information see Package Information section.
${ }^{7}$ For AD537/883B specifications, refer to Analog Devices Military Products Databook.

AD650

## FEATURES

V/F Conversion to $\mathbf{1 M H z}$
Reliable Monolithic Construction
Very Low Nonlinearity
$0.002 \%$ typ at 10 kHz
0.005\% typ at 100kHz
$0.07 \%$ typ at 1 MHz
Input Offset Trimmable to Zero
CMOS or TTL Compatible
Unipolar, Bipolar, or Differential V/F
V/F or F/V Conversion
Available in Surface Mount
MIL-STD-883-Compliant Versions Available

## PRODUCT DESCRIPTION

The AD650 V/F/V (voltage-to-frequency or frequency-to-voltage converter) provides a combination of high frequency operation and low nonlinearity previously unavailable in monolithic form. The inherent monotonicity of the V/F transfer function makes the AD650 useful as a high-resolution analog-to-digital converter. A flexible input configuration allows a wide variety of input voltage and current formats to be used, and an open-collector output with separate digital ground allows simple interfacing to either standard logic families or opto-couplers.

The linearity error of the AD650 is typically 20ppm ( $0.002 \%$ of full scale) and $50 \mathrm{ppm}(0.005 \%)$ maximum at 10 kHz full scale. This corresponds to approximately 14-bit linearity in an analog-todigital converter circuit. Higher full-scale frequencies or longer count intervals can be used for higher resolution conversions. The AD650 has a useful dynamic range of six decades allowing extremely high resolution measurements. Even at 1 MHz full scale, linearity is guaranteed less than $1000 \mathrm{ppm}(0.1 \%)$ on the AD650KN, KP, BD and SD grades.
In addition to analog-to-digital conversion, the AD650 can be used in isolated analog signal transmission applications, phased-locked-loop circuits, and precision stepper motor speed controllers. In the F/V mode, the AD650 can be used in precision tachometer and FM demodulator circuits.
The input signal range and full-scale output frequency are userprogrammable with two external capacitors and one resistor. Input offset voltage can be trimmed to zero with an external potentiometer.
The AD650JN and AD650KN are offered in a plastic 14-pin DIP package. The AD650JP and AD650KP are available in a

PIN CONFIGURATION


20-pin plastic leaded chip carrier (PLCC). Both plastic packaged versions of the AD650 are specified for the commerical ( 0 to $+70^{\circ} \mathrm{C}$ ) temperature range. For industrial temperature range $\left(-25^{\circ} \mathrm{C}\right.$ to $+85^{\circ} \mathrm{C}$ ) applications, the AD650AD and AD650BD are offered in a ceramic package. The AD650SD is specified for the full $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ extended temperature range.

## PRODUCT HIGHLIGHTS

1. In addition to very high linearity, the AD650 can operate at full scale output frequency up to 1 MHz . The combination of these two features makes the AD650 an inexpensive solution for applications requiring high resolution monotonic $A / D$ conversion.
2. The AD650 has a very versatile architecture that can be configured to accommodate bipolar, unipolar, or differential input voltages, or unipolar input currents.
3. TTL or CMOS compatibility is achieved using an open collector frequency output. The pullup resistor can be connected to voltages up to +30 V , or +15 V or +5 V for conventional CMOS or TTL logic levels.
4. The same components used for $\mathrm{V} / \mathrm{F}$ conversion can also be used for $\mathrm{F} / \mathrm{V}$ conversion by adding a simple logic biasing network and reconfiguring the AD650.
5. The AD650 provides separate analog and digital grounds. This feature allows prevention of ground loops in real-world applications.
6. The AD650 is available in versions compliant with MIL-STD883. Refer to the Analog Devices Military Products Databook or current AD650/883B data sheet for detailed specifications.

## AD650-SPECIFICATIONS <br> (@ $+25^{\circ} \mathrm{C}$ with $\mathrm{V}_{\mathrm{s}}= \pm 15 \mathrm{~V}$ unless otherwise noted)



## NOTES

${ }^{1}$ Nonlinearity is defined as deviation from a straight line from zero to full scale, expressed as a fraction of full scale.
${ }^{2}$ Full scale calibration error adjustable to zero.
${ }^{3}$ Measured at full scale output frequency of 100 kHz .
${ }^{4}$ Refer to F/V conversion section of the text.
${ }^{\text {S }}$ Referred to digital ground.
${ }^{6} \mathrm{D}=$ Ceramic DIP; $\mathrm{N}=$ Plastic DIP; $\mathbf{P}=$ Plastic Leaded Chip Carrier.
For outline information see Package Information section.
Specifications subject to change without notice.

Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All $\min$ and max specifications are guaranteed, although only those shown in boldface are tested on all production units.

## ABSOLUTE MAXIMUM RATINGS

Total Supply Voltage $+\mathrm{V}_{\mathrm{S}}$ to $-\mathrm{V}_{\mathrm{S}}$. . . . . . . . . . . . 36V
Storage Temperature Ceramic . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+165^{\circ} \mathrm{C}$
Plastic . . . . . . . . $-25^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Differential Input Voltage (Pins 2 \& 3) . . . . . . . . . $\pm 10 \mathrm{~V}$
Maximum Input Voltage . . . . . . . . . . . . . . . . . $\pm \mathrm{V}_{\mathrm{S}}$
Open Collector Output Voltage Above Digital GND . . 36V
Current . . . . . . . . . . 50 mA
Amplifier Short Ckt to Ground . . . . . . . . . . . Indefinite
Comparator Input Voltage (Pin 9) . . . . . . . . . . . . . $\pm \mathrm{V}_{\mathrm{S}}$


## CIRCUIT OPERATION

## UNIPOLAR CONFIGURATION

The AD650 is a charge balance voltage-to-frequency converter. In the connection diagram shown in Figure 1, or the block diagram of Figure 2a, the input signal is converted into an equivalent current by the input resistance $R_{I N}$. This current is exactly balanced by an internal feedback current delivered in short, timed bursts from the switched 1 mA internal current source. These bursts of current may be thought of as precisely defined packets of charge. The required number of charge packets, each producing one pulse of the output transistor, depends upon the amplitude of the input signal. Since the number of charge packets delivered per unit time is dependent on the input signal amplitude, a linear voltage-to-frequency transformation will be accomplished. The frequency output is furnished via an open collector transistor.

ORDERING GUIDE

| Model ${ }^{1}$ | Gain <br> Tempco ppm $/{ }^{\circ} \mathrm{C}$ 100 kHz | 1 MHz <br> Linearity | Specified <br> Temperature <br> Range ${ }^{\circ} \mathrm{C}$ | Package |
| :---: | :---: | :---: | :---: | :---: |
| AD650JN | 150 typ | 0.1\% typ | 0 to +70 | Plastic DIP |
| AD650KN | 150 typ | 0.1\% max | 0 to +70 | Plastic DIP |
| AD650JP | 150 typ | 0.1\% typ | 0 to +70 | PLCC |
| AD650KP | 150 typ | 0.1\% max | 0 to +70 | PLCC |
| AD650AD | 150 max | 0.1\% typ | -25 to +85 | Ceramic |
| AD650BD | 150 max | 0.1\% max | -25 to +85 | Ceramic |
| AD650SD | 150 max | 0.1\% max | -55 to +125 | Ceramic |

NOTE
${ }^{1}$ For details on grade and package offerings screened in accordance with MIL-STD-883, refer to the Analog Devices Military Products Databook or current AD650/883B data sheet.

## FEATURES

Full-Scale Frequency (Up to 2MHz) Set by External System Clock<br>Extremely Low Linearity Error $\mathbf{( 0 . 0 0 5 \%} \max$ at $\mathbf{1 M H z}$ FS, $\mathbf{0 . 0 2 \%}$ max at $\mathbf{2 M H z}$ FS)<br>No Critical External Components Required<br>Accurate 5V Reference Voltage<br>Low Drift (25ppm/ ${ }^{\circ} \mathrm{C}$ max)<br>Dual or Single Supply Operation<br>Voltage or Current Input<br>MIL-STD-883 Compliant Versions Available

## PRODUCT DESCRIPTION

The AD652 Synchronous Voltage-to-Frequency Converter (SVFC) is a powerful building block for precision analog-to-digital conversion, offering typical nonlinearity of $0.002 \%$ ( $0.005 \%$ maximum) at a 100 kHz output frequency. The inherent monotonicity of the transfer function and wide range of clock frequencies allows the conversion time and resolution to be optimized for specific applications.
The AD652 uses a variation of the popular charge-balancing technique to perform the conversion function. The AD652 uses an external clock to define the full-scale output frequency, rather than relying on the stability of an external capacitor. The result is a more stable, more linear transfer function, with significant application benefits in both single- and multi-channel systems.
Gain drift is minimized using a precision low-drift reference and low-TC on-chip thin-film scaling resistors. Furthermore, the initial gain error is reduced to less than $0.5 \%$ by the use of laser-wafer-trimming.
The analog and digital sections of the AD652 have been designed to allow operation from a single-ended power source, simplifying its use with isolated power supplies.
The AD652 is available in five performance grades. The 20-pin PLCC packaged JP and KP grades are specified for operation over the 0 to $+70^{\circ} \mathrm{C}$ commercial temperature range. The 16 -pin cerdip-packaged $A Q$ and $B Q$ grades are specified for operation over the $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ industrial temperature range, and the AD652SQ is available for operation over the full $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ extended temperature range.

## FUNCTIONAL BLOCK DIAGRAM



## PRODUCT HIGHLIGHTS

1. The use of an external clock to set the full-scale frequency allows the AD652 to achieve linearity and stability far superior to other monolithic VFCs. By using the same clock to drive the AD652 and (through a suitable divider) also set the counting period, conversion accuracy is maintained independent of variations in clock frequency.
2. The AD652 Synchronous VFC requires only a single external component (a noncritical integrator capacitor) for operation.
3. The AD652 includes a buffered, accurate 5 V reference which is available to the user.
4. The clock input of the AD652 is TTL and CMOS compatible and can also be driven by sources referred to the negative power supply. The flexible open-collector output stage provides sufficient current sinking capability for TTL and CMOS logic, as well as for optical couplers and pulse transformers. A capacitor-programmable one-shot is provided for selection of optimum output pulse width for power reduction.
5. The AD652 can also be configured for use as a synchronous F/V converter for isolated analog signal transmission.
6. The AD652 is available in versions compliant with MIL-STD883. Refer to the Analog Devices Military Products Databook or current AD652/883B data sheet for detailed specifications.


| Parameter | AD652JP/AQ/SQ |  |  | AD652KP/BQ |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max |  |
| OUTPUT STAGE |  |  |  |  |  |  |  |
| $\mathrm{V}_{\text {OL }}\left(\mathrm{I}_{\text {OUT }}=10 \mathrm{~mA}\right.$ ) |  |  | 0.4 |  |  | 0.4 | V |
| $\mathrm{I}_{\mathrm{OL}}$ |  |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{OL}}<0.8 \mathrm{~V}$ |  |  | 15 |  |  | 15 | mA |
| $\mathrm{V}_{\text {OL }}<0.4 \mathrm{~V}, \mathrm{~T}_{\text {min }}-\mathrm{T}_{\text {max }}$ |  |  | 8 |  |  | 8 | mA |
| $\mathrm{I}_{\mathrm{OH}}$ (Off Leakage) |  | 0.01 | 10 |  | 0.01 | 10 | $\mu \mathrm{A}$ |
| Delay Time, Positive Clock Edge to Output Pulse | 150 | 200 | 250 | 150 | 200 | 250 | ns |
| Fall Time ( $\mathrm{Load}=500 \mathrm{pF}$ and $\left.\mathrm{I}_{\text {SINK }}=5 \mathrm{~mA}\right)$ |  | 100 |  |  | 100 |  | ns |
| Output Capacitance |  | 5 |  |  | 5 |  | pF |
| OUTPUTONE-SHOT |  |  |  |  |  |  |  |
| Pulse Width |  |  |  |  |  |  |  |
| $\mathrm{C}_{\mathrm{OS}}=300 \mathrm{pF}$ | 1 | 1.5 | 2 | 1 | 1.5 | 2 | $\mu \mathrm{s}$ |
| $\mathrm{C}_{\mathrm{OS}}=1000 \mathrm{pF}$ | 4 | 5 | 6 | 4 | 5 | 6 | $\mu s$ |
| REFERENCE OUTPUT |  |  |  |  |  |  |  |
| Voltage | 4.950 | 5.0 | 5.050 | 4.975 | 5.0 | 5.025 |  |
| Drift |  |  | 100 |  |  | 50 | ppm/ ${ }^{\circ} \mathrm{C}$ |
| Output Current |  |  |  |  |  |  |  |
| Source | 10 |  |  | 10 |  |  | mA |
| Sink | 100 | 500 |  | 100 | 500 |  | $\mu \mathrm{A}$ |
| Power Supply Rejection |  |  |  |  |  |  |  |
| Output Impedance (Sourcing Current) |  | 0.3 | 2 |  | 0.3 | 2 | $\Omega$ |
| POWER SUPPLY |  |  |  |  |  |  |  |
| Rated Voltage |  | $\pm 15$ |  |  | $\pm 15$ |  | V |
| Operating Range |  |  |  |  |  |  |  |
| Dual Supplies | $\pm 6$ | $\pm 15$ | $\pm 18$ | $\pm 6$ | $\pm 15$ | $\pm 18$ | V |
| Single Supply ( $-\mathrm{V}_{\mathrm{S}}=0$ ) | + 12 |  | +36 | + 12 |  | +36 | V |
| Quiescent Current |  | $\pm 11$ | $\pm 15$ |  | $\pm 11$ | $\pm 15$ | mA |
| Digital Common | $-\mathrm{V}_{\text {s }}$ |  | $+V_{S}-4$ | $-\mathrm{V}_{\text {s }}$ |  | $+\mathrm{V}_{\text {S }}-4$ | V |
| Analog Common | $-V_{S}$ |  | $+\mathrm{V}_{\text {S }}$ | $-V_{\text {S }}$ |  | $+\mathrm{V}_{\text {S }}$ | V |
| TEMPERATURE RANGE |  |  |  |  |  |  |  |
| Specified Performance |  |  |  |  |  |  |  |
| JP, KP Grade | 0 |  | +70 | 0 |  | +70 | ${ }^{\circ} \mathrm{C}$ |
| AQ, BQ Grade | -40 |  | +85 | -40 |  | +85 | ${ }^{\circ} \mathrm{C}$ |
| SQ Grade | -55 |  | + 125 |  |  |  | ${ }^{\circ} \mathrm{C}$ |

NOTES
${ }^{1}$ Referred to internal $\mathrm{V}_{\text {REF }}$. In PLCC package, tested on 10 V input range only.
Specifications in boldface are $100 \%$ tested at final test and are used to measure outgoing quality levels.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS

Total Supply Voltage $+\mathrm{V}_{\mathrm{S}}$ to $-\mathrm{V}_{\text {S }}$. . . . . . . . . . . . 36V
Maximum Input Voltage (Figure 6) . . . . . . . . . . . . 36V
Maximum Output Current (Open Collector Output) . . 50 mA
Amplifier Short Circuit to Ground • . . . . . . . . . Indefinite
Storage Temperature Range: Cerdip . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

$$
\text { PLCC . . . . }-65^{\circ} \mathrm{C} \text { to }+150^{\circ} \mathrm{C}
$$

## DEFINITIONS OF SPECIFICATIONS

GAIN ERROR - The gain of a voltage-to-frequency converter is that scale factor setting that provides the nominal conversion relationship, e.g. 1 MHz full scale. The "gain error". is the difference in slope between the actual and ideal transfer functions for the V-F converter.
LINEARITY ERROR - The "linearity error" of a V-F is the deviation of the actual transfer function from a straight line passing through the endpoints of the transfer function.
GAIN TEMPERATURE COEFFICIENT - The gain temperature coefficient is the rate of change in full-scale frequency as a function of the temperature from $+25^{\circ} \mathrm{C}$ to $\mathrm{T}_{\text {min }}$ or $\mathrm{T}_{\text {max }}$.

ORDERING GUIDE

| Part <br> Number ${ }^{1}$ | Gain <br> Drift <br> ppm/ ${ }^{\circ} \mathrm{C}$ <br> 100 kHz | 1 MHz <br> Linearity \% | Specified Temperature Range ${ }^{\circ} \mathrm{C}$ | Package Options ${ }^{2}$ |
| :---: | :---: | :---: | :---: | :---: |
| AD652JP | 50 max | 0.02 max | 0 to +70 | PLCC (P-20A) |
| AD652KP | 25 max | 0.005 max | 0 to +70 | PLCC (P-20A) |
| AD652AQ | 50 max | 0.02 max | -40 to +85 | Cerdip (Q-16) |
| AD652BQ | 25 max | 0.005 max | -40 to +85 | Cerdip (Q-16) |
| AD652SQ | 50 max | 0.02 max | -55 to +125 | Cerdip (Q-16) |

## NOTES

${ }^{1}$ For details on grade and package offerings screened in accordance with MIL-STD-883, refer to the Analog Devices Military Products Databook or current AD652/883 data sheet.
${ }^{2} \mathrm{P}=$ Plastic Leaded Chip Carrier; $\mathrm{Q}=$ Cerdip. For outline information see Package Information section.

PIN CONFIGURATIONS

| PIN | "Q" CERDIP | "P" PLCC |
| :---: | :---: | :---: |
| 1 | $+V_{s}$ | NC |
| 2 | TRIM | $+V_{s}$ |
| 3 | TRIM | NC |
| 4 | OP AMP OUT | OP AMP OUT |
| 5 | OP AMP " - " | OP AMP ${ }^{\text {- }}$ " |
| 6 | OP AMP " + " | OP AMP " + " |
| 7 | 10 VOLTINPUT | 5 VOLTINPUT |
| 8 | - $\mathbf{V}_{\mathbf{S}}$ | 10 VOLT INPUT |
| 9 | Cos | 8 VOLTINPUT |
| 10 | CLOCK INPUT | OPTIONAL 10V INPUT |
| 11 | FREQ OUT | $-V_{s}$ |
| 12 | DIGITAL GND | Cos. |
| 13 | ANALOG GND | CLOCK INPUT |
| 14 | COMP". - " | FREQ OUT |
| 15 | COMP" ${ }^{\text {+ }}$ " | DIGITAL GROUND |
| 16 | COMP REF | ANALOG GND |
| 17 |  | COMP" - " |
| 18 |  | COMP ${ }^{\prime}+{ }^{\prime \prime}$ |
| 19 |  | NC |
| 20 |  | COMP REF |

## THEORY OF OPERATION

A synchronous VFC is similar to other voltage-to-frequency converters in that an integrator is used to perform a charge-balance of the input signal with an internal reference current. However, rather than using a one-shot as the primary timing element which requires a high quality and low drift capacitor, a synchronous voltage-to-frequency converter (SVFC) uses an external clock; this allows the designer to determine the system stability and drift based upon the external clock selected. A crystal oscillator may also be used if desired.
The SVFC architecture provides other system advantages besides low drift. If the output frequency is measured by counting pulses gated to a signal which is derived from the clock, the clock stability is unimportant and the device simply performs as a voltage controlled frequency divider, producing a high resolution A/D. If a large number of inputs must be monitored simultaneously in a system, the controlled timing relationship between the frequency output pulses and the user supplied clock greatly simplifies this signal acquisition. Also, if the clock signal is provided by a VFC, then the output frequency of the SVFC will be proportional to the product of the two input voltages. Hence, multiplication and A-to-D conversion on two signals are performed simultaneously.
The pinouts of the AD652 SVFC are shown in Figure 1.


Figure 1a. AD652 Cerdip Pin Configuration


Figure 1b. AD652 PLCC Pin Configuration

Low Cost Monolithic
Voltage-to-Frequency Converter

FEATURES
Low Cost
Single or Dual Supply, 5 to $\mathbf{3 6}$ Volts, $\pm 5 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$
Full Scale Frequency Up to $\mathbf{5 0 0 k H z}$
Minimum Number of External Components Needed
Versatile Input Amplifier
Positive or Negative Voltage Modes
Negative Current Mode
High Input Impedance, Low Drift
Low Power: 2.0mA Quiescent Current
Low Offset: 1mV

## FUNCTIONAL BLOCK DIAGRAM



## PRODUCT HIGHLIGHTS

1. Packaged in both an 8-pin mini-DIP and an 8-pin SOIC package, the AD654 is a complete V/F converter requiring only an RC timing network to set the desired full scale frequency and a selectable pull-up resistor for the open-collector output stage. Any full scale input voltage range from 100 mV to 10 volts (or greater, depending on $+\mathrm{V}_{\mathrm{s}}$ ) can be accommodated by proper selection of the timing resistor. The full scale frequency is then set by the timing capacitor from the simple relationship, $f=V / 10 R C$.
2. A minimum number of low cost external components are necessary. A single RC network is all that is required to set up any full scale frequency up to 500 kHz and any full scale input voltage up to $\pm 30 \mathrm{~V}$.
3. Plastic packaging allows low cost implementation of the standard VFC applications: A/D conversion, isolated signal transmission, F/V conversion, phase-locked loops, and tuning switched-capacitor filters.
4. Power supply requirements are minimal; only 2.0 mA of quiescent current is drawn from the single positive supply from 4.5 to 36 volts. In this mode, positive inputs can vary from 0 volts (ground) to ( $+\mathrm{V}_{\mathrm{s}}-4$ ) volts. Negative inputs can easily be connected for below ground operation.
5. The versatile open-collector output stage can sink more than 10 mA with a saturation voltage less than 0.4 volts. The Logic Common terminal can be connected to any level between ground (or $-V_{S}$ ) and 4 volts below $+V_{S}$. This allows easy direct interface to any logic family with either positive or negative logic levels.

| Model | Min | AD654JN/JR Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: |
| CURRENT-TO-FREQUENCY CONVERTER |  |  |  |  |
| Frequency Range | 0 |  | 500 | kHz |
| Nonlinearity ${ }^{1}$ |  |  |  |  |
| $\mathrm{f}_{\text {max }}=250 \mathrm{kHz}$ |  | 0.06 | 0.1 | \% |
| $\mathrm{f}_{\text {max }}=500 \mathrm{kHz}$ |  | 0.20 | 0.4 | \% |
| Full Scale Calibration Error |  |  |  |  |
| $\mathrm{C}=390 \mathrm{pF}, \mathrm{I}_{\mathrm{IN}}=1.000 \mathrm{~mA}$ | -10 |  | 10 | \% |
| vs. Supply ( $\mathrm{f}_{\text {max }} \leq 250 \mathrm{kHz}$ ) |  |  |  |  |
| $\mathrm{V}_{\mathrm{S}}=+4.75$ to +5.25 V |  | 0.20 | 0.40 | \%/V |
| $\mathrm{V}_{\mathrm{s}}=+5.25$ to +16.5 V |  | 0.05 | 0.10 | \%/V |
| vs. Temp (0 to $70^{\circ} \mathrm{C}$ ) |  | 50 |  | ppm/ ${ }^{\circ} \mathrm{C}$ |
| ANALOG INPUT AMPLIFIER |  |  |  |  |
| (Voltage-to-Current Converter) |  |  |  |  |
| Voltage Input Range |  |  |  |  |
| Single Supply | 0 |  | $\left(+V_{S}-4\right)$ | V |
| Dual Supply | $-\mathrm{V}_{\mathrm{S}}$ |  | $\left(+V_{S}-4\right)$ | V |
| Input Bias Current |  |  |  |  |
| (Either Input) |  | 30 | 50 | nA |
| Input Offset Current |  | 5 |  | nA |
| Input Resistance (Non-Inverting) |  | 250 |  | $\mathrm{M} \Omega$ |
| Input Offset Voltage |  | 0.5 | 1.0 | mV |
| vs. Supply |  |  |  |  |
| $\mathrm{V}_{\mathrm{S}}=+4.75$ to +5.25 V |  | 0.1 | 0.25 | $\mathrm{mV} / \mathrm{V}$ |
| $\mathrm{V}_{\mathrm{s}}=+5.25$ to +16.5 V |  | 0.03 | 0.1 | $\mathrm{mV} / \mathrm{V}$ |
| vs. $\operatorname{Temp}\left(0\right.$ to $70^{\circ} \mathrm{C}$ ) |  | 4 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| OUTPUT INTERFACE (Open Collector Output) <br> (Symmetrical Square Wave) |  |  |  |  |
| Output Sink Current in Logic " 0 " ${ }^{2}$ |  |  |  |  |
| $\mathrm{V}_{\text {Out }}=0.4 \mathrm{~V}$ max, $25^{\circ} \mathrm{C}$ | 10 | 20 |  | mA |
| $\mathrm{V}_{\text {OUT }}=0.4 \mathrm{~V}$ max, 0 to $70^{\circ} \mathrm{C}$ | 5 | 10 |  | mA |
| Output Leakage Current in Logic " 1 " |  | 10 | 100 | nA |
| 0 to $70^{\circ} \mathrm{C}$ |  | 50 | 500 | nA |
| Logic Common Level Range | $-V_{s}$ |  | $\left(+V_{S}-4\right)$ | V |
| Rise/Fall Times ( $\left.\mathrm{C}_{\mathrm{T}}=0.01 \mu \mathrm{~F}\right)$ |  |  |  |  |
| $\mathbf{I}_{\mathbf{I N}}=\operatorname{lmA}$ |  | 0.2 |  | $\mu \mathrm{s}$ |
| $\mathrm{I}_{\text {IN }}=1 \mu \mathrm{~A}$ |  | 1 |  | $\mu \mathrm{s}$ |
| POWER SUPPLY |  |  |  |  |
| Voltage, Rated Performance | 4.5 |  | 16.5 | V |
| Voltage, Operating Range |  |  |  |  |
| Single Supply | 4.5 |  | 36 | V |
| Dual Supply | $\pm 5$ |  | $\pm 18$ | V |
| Quiescent Current |  |  |  |  |
| $\mathbf{V}_{\mathbf{S}}($ Total $)=5 \mathrm{~V}$ |  | 1.5 | 2.5 | mA |
| $\mathrm{V}_{\mathrm{S}}($ Total $)=30 \mathrm{~V}$ |  | 2.0 | 3.0 | mA |
| TEMPERATURE RANGE Operating Range | -40 |  | 85 | ${ }^{\circ} \mathrm{C}$ |
| PACKAGE OPTIONS ${ }^{3}$ | $\begin{aligned} & \text { AD654JR } \\ & \text { AD654JN } \end{aligned}$ |  |  |  |
| SOIC(R-8) |  |  |  |  |
| Plastic DIP(N-8) |  |  |  |  |

## NOTES

${ }^{1} \mathrm{Atf}_{\text {max }}=250 \mathrm{kHz} ; \mathrm{R}_{\mathrm{T}}=1 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{T}}=390 \mathrm{pF}, \mathrm{I}_{\mathrm{IN}}=0.1 \mathrm{~mA}$.
$f_{\text {max }}=500 \mathrm{kHz} ; \mathrm{R}_{\mathrm{T}}=1 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{T}}=200 \mathrm{pF}, \mathrm{I}_{\mathrm{IN}}=0-1 \mathrm{~mA}$.
${ }^{2}$ The sink current is the amount of current that can flow into Pin 1 of the AD654 while maintaining a maximum voltage of 0.4 V between Pin 1 and Logic Common.
${ }^{3} \mathrm{~N}=$ Plastic DIP; R = SOIC. For outline information see Package Information section.
Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels.
All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.
Specifications subject to change without notice.

Maximum Output Current
Instantaneous . . . . . . . . . . . . . . . . . . . . 50 mA
Sustained . . . . . . . . . . . . . . . . . . 25 mA
Logic Common to - $\mathrm{V}_{\mathrm{S}}$. . . . . . . -500 mV to $\left(+\mathrm{V}_{\mathbf{S}}-4\right)$
Storage Temperature Range . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

## CIRCUIT OPERATION

The AD654's block diagram appears in Figure 1. A versatile operational amplifier serves as the input stage; its purpose is to convert and scale the input voltage signal to a drive current in the NPN follower. Optimum performance is achieved when, at the full scale input voltage, a 1 mA drive current is delivered to the current-to-frequency converter (an astable multivibrator). The drive current provides both the bias levels and the charging current to the externally connected timing capacitor. This "adaptive" bias scheme allows the oscillator to provide low nonlinearity over the entire current input range of 100 nA to 2 mA . The square wave oscillator output goes to the output driver which provides a floating base drive to the NPN power transistor. This floating drive allows the logic interface to be referenced to a level other than $-V_{S}$.


Figure 1. Standard V-F Connection for Positive Input Voltages

## V/F CONNECTION FOR POSITIVE INPUT VOLTAGES

In the connection scheme of Figure 1, the input amplifier presents a very high ( $250 \mathrm{M} \Omega$ ) impedance to the input voltage, which is converted into the proper drive current by the scaling resistors at pin 3. Resistors R1 and R2 are selected to provide a 1 mA full scale current with enough trim range to accommodate the AD654's $10 \%$ FS error and the components' tolerances. Full scale currents other than $\operatorname{lmA}$ can be chosen, but linearity will be reduced; 2 mA is the maximum allowable drive. The AD654's positive input voltage range spans from $-\mathrm{V}_{\mathbf{S}}$ (ground in single supply operation) to four volts below the positive supply. Power supply
rejection degrades as the input exceeds $\left(+V_{S}-3.75 \mathrm{~V}\right)$ and at ( $+\mathrm{V}_{\mathrm{S}}-3.5 \mathrm{~V}$ ) the output frequency goes to zero.
As indicated by the scaling relationship in Figure 1, a $0.01 \mu \mathrm{~F}$ timing capacitor will give a 10 kHz full scale frequency, and $0.001 \mu \mathrm{~F}$ will give 100 kHz with a $\operatorname{lmA}$ drive current. Good V/F linearity requires the use of a capacitor with low dielectric absorption (DA), while the most stable operation over temperature calls for a component having a small tempco. Polystyrene, polypropylene, or Teflon* capacitors are preferred for tempco and dielectric absorption; other types will degrade linearity. The capacitor should be wired very close to the AD654. In Figure 1, Schottky diode CR1 (MBD101) prevents logic common from dropping more than 500 mV below $-\mathrm{V}_{\mathrm{S}}$. This diode is not required if $-V_{S}$ is equal to logic common.

## V/F CONNECTIONS FOR NEGATIVE INPUT VOLTAGE OR CURRENT

The AD654 can accommodate a wide range of negative input voltages with proper selection of the scaling resistor, as indicated in Figure 2. This connection, unlike the buffered positive connection, is not high impedance because the signal source must supply the 1 mA F.S. drive current. However, large negative voltages beyond the supply can be handled easily by modifying the scaling resistors appropriately. If the input is a true current source, R1 and R2 are not used. Again, diode CR1 prevents latch-up by insuring Logic Common does not drop more than 500 mV below $-\mathrm{V}_{\mathrm{S}}$. The clamp diode (MBD101) protects the AD654 input from "below $-V_{s}$ " inputs.


Figure 2. V-F Connections for Negative Input Voltages or Current

[^68]
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Selection Tree - Data Acquisition Subsystems


Selection Guide—Data Acquisition Subsystems

| Model | Resolution Bits | Throughput Rate kHz | No. <br> Channels | Bus <br> Interface | Package Options ${ }^{1}$ | Temp Ranges ${ }^{2}$ | Comments | Page ${ }^{3}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| AD7716 | 22 | 0.30 | 4 | Serial | P, S | I | Quad 22-Bit Sigma-Delta ADC, Low Power | 5-40 |
| AD1382 | 16 | 500 | 1 | 8, $\mu \mathrm{P}$ | D | C | High Speed Sampling ADC | 5-20 |
| AD1385 | 16 | 500 | 1 | 8, $\mu \mathrm{P}$ | D | C, M | Autocalibrated, Wide Temp Sampling ADC | 5-24 |
| AD7715 | 16 | 20-200 Hz | 1 | Serial, $\boldsymbol{\mu} \mathbf{P}$ | N, R | I | Sigma-Delta ADC, PGA Gain 1-128, 3 V or 5 V Supply | 5-28 |
| AD1B60 | 16 | 100 Hz | 4 | Serial, $\mu \mathbf{P}$ | J, S | I | Complete Sensor-to-Digital Conditioning and Conversion | 5-5 |
| AD7869 | 14 | 83 | 1 | Serial, $\mu \mathbf{P}$ | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I | Complete Analog I/O with DAC | 5-72 |
| AD7891 | 12 | 600 | 8 | 8/12, Serial, $\mu$ P | P, S | I | 5 V Supply, CMOS, High Speed | 5-92 |
| AD1341 | 12 | 150 | 16/8 | 16 | Z | C, M/ | Complete, Programmable DAS with Fast Bus Interface | CII 7-5 |
| AD7890 | 12 | 100 | 8 | Serial | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | 5 V Supply, CMOS, Sampling ADC | 5-76 |
| AD7868 | 12 | 83 | 1 | Serial, $\boldsymbol{\mu} \mathbf{P}$ | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I | Complete Analog I/O with DAC | 5-68 |
| AD363R | 12 | 25 | 16/8 | 12 | D | C, M | 16-Channel 12-Bit DAS | CII 7-5 |
| AD364R | 12 | 20 | 16/8 | 12 | D | C, M | High Speed 16-Channel 12-Bit DAS | CII 7-5 |
| AD7850 | 12 | 10 | 1 | Serial | N, P | C | Small Signal DAS with Instrumentation Amplifiers and Reference | D |
| AD7776 | 10 | 400 | 1 | 10, $\mu \mathrm{P}$ | R | I | Single Supply, CMOS, Offset Reference | 5-54 |
| AD7777 | 10 | 400 | 4 | 10, $\mu \mathrm{P}$ | N, R | I | Single Supply, CMOS, Dual Sampling | 5-54 |
| AD7778 | 10 | 400 | 8 | 10, $\mu \mathrm{P}$ | S | I | Single Supply, CMOS, Dual Sampling | 5-54 |
| AD8401 | 8 | 500 | 4 | 8, $\mu \mathrm{P}$ | R | I | 5 V Complete I/O Subsystem with DAC | 5-102 |
| AD7824 | 8 | 400 | 4 | 8, $\mu \mathrm{P}$ | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M | CMOS, 4-Channel Sampling ADC | 5-64 |
| AD7828 | 8 | 400 | 8 | 8, $\mu \mathrm{P}$ | E, N, P, Q | C, I, M | CMOS, 8-Channel Sampling ADC | 5-64 |

${ }^{1}$ Package Options: D = Hermetic DIP, Ceramic or Metal; E Ceramic Leadless Chip Carrier; F = Ceramic Flatpack; G = Ceramic Pin Grid Array; H = Hermetic Metal Can; J $=\mathrm{J}$-Leaded Ceramic Package; $M=$ Hermetic Metal Can DIP; N = Plastic or Epoxy Sealed DIP; P = Plastic Leaded Chip Carrier; $\mathrm{Q}=$ Cerdip; $\mathrm{R}=$ Small Outline "SOIC" Package; RS = SSOP-Shrink Small Outine Package; $\mathrm{S}=$ Plastic Quad Flatpack; ST = Thin Quad Flatpack; $\mathrm{T}=$ TO-92; $\mathrm{U}=$ TSOP-Thin Small Outline Package; W $=$ Nonhermetic Ceramic/Glass DIP; $\mathrm{Y}=$ Single-In-Line "SIP" Package; $\mathrm{Z}=$ Ceramic Leaded Chip Carrier. ${ }^{2}$ Temperature Ranges: $\mathrm{C}=$ Commercial, $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C} ; \mathrm{I}=$ Industrial, $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ (Some older products $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ); $\mathrm{M}=$ Military, $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. If a device has military grade offerings, the M temperature designator will be followed by: / to indicate 883B, ${ }_{J}$ for JAN, ${ }_{D}$ for SMD, and ${ }_{s}$ for space level.
${ }^{3} \mathrm{CII}=$ Data Converter Reference Manual, Volume II; D = Data Sheet. All other entries refer to this volume.
Boldface Type: Data sheet information in this volume.

Intelligent Digitizing Signal Conditioner

FEATURES

- Complete Sensor-to-Digital Signal Conditioning and Data Conversion
- Multiple Input Ranges

Thermocouples: J, K, T, E, R, S, and B
RTDs: $100 \Omega$ Platinum ( $\alpha=385$ and 392)
Voltage: Ten Ranges from $\pm 10 \mathrm{mV}$ to $\pm 10 \mathrm{~V}$
Two Custom Ranges (User Defined)

- High Resolution: $\pm 0.15^{\circ} \mathrm{C}$ (Typical, Temperature Input) or $\pm 0.0015 \%$ (Typical, Voltage Input)
- High Accuracy: $\pm 0.2^{\circ} \mathrm{C}$ (Typical, RTD Input) or $\pm 0.005 \%$ (Typical, Voltage Input)
- Cold Junction Compensation for Thermocouples
- Open Thermocouple Detection
- RTD Excitation
- Lead Resistance Compensation for RTDs
- Autozeroing, Data Scaling, and Linearization
- Data Output in Engineering Units •
- 2-Wire Asynchronous Communication I/O Port
- High Speed Synchronous Data Output Port
- Eight Integration Times: $2 \mathbf{m s}$ to $\mathbf{2 0 0} \mathbf{~ m s}$
- Internal EEPROM Stores Calibration and Configuration Parameters


## APPLICATIONS

Industrial Temperature Measurement Systems
Process Control Systems
Multichannel Thermocouple/RTD Systems Analytical Instruments

## GENERAL DESCRIPTION

The AD1B60 is an intelligent, microcontroller-based device that performs signal conditioning, excitation, compensation, linearization, and analog-to-digital conversion for a variety of low bandwidth industrial and analytical signals. Due to its highly integrated, mixed-signal design, the AD1B60 is small and inexpensive, offering designers increased flexibility and performance.
The AD1B60 is suited primarily for use with thermocouples and resistance temperature detectors (RTDs), but also accepts a broad range of low and high level voltage inputs. The AD1B60 converts sensor inputs to compensated, linearized, scaled, and autozeroed outputs represented in engineering units: degrees Celsius or volts.

FUNCTIONAL BLOCK DIAGRAM


Four modes of cold junction compensation (CJC) are supported for thermocouple applications. The AD1B60 also provides lead resistance compensation for 3 -wire or 4 -wire RTD connections.
Data is transmitted serially to simplify use of external optical and/or magnetic isolation devices. The AD1B60 has a bidirectional asynchronous communications port for control and for data output. Data is also available via a high-speed synchronous data output port.
Configuration parameters such as the input range and integration time of the AD1B60 can be programmed, both prior to installation and in the application. The AD1B60 incorporates EEPROM to store default and user-specified configuration and calibration values. No battery backups, potentiometers, or userdeveloped calibration software routines are required and no recalibration is necessary when the input range is changed.


| Parameter | AD1B60BS, AD1B60BJ |  |  | Unit | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max |  |  |
| ACCURACY (ERROR) |  |  |  |  |  |
| Range 0 ( $\pm 10 \mathrm{mV}$ ) |  | $\pm 0.06$ | $\pm 0.11$ | \% FSR | Notes 1 and 2 (All Ranges); at $+25^{\circ} \mathrm{C}$ |
| Range $1( \pm 20 \mathrm{mV}$ ) |  | $\pm 0.03$ | $\pm 0.06$ | \% FSR |  |
| Range $2( \pm 50 \mathrm{mV}$ ) |  | $\pm 0.015$ | $\pm 0.03$ | \% FSR |  |
| Range 3 ( $\pm 100 \mathrm{mV}$ ) |  | $\pm 0.008$ | $\pm 0.015$ | \% FSR |  |
| Range 4 ( $\pm 200 \mathrm{mV}$ ) |  | $\pm 0.005$ | $\pm 0.008$ | \% FSR |  |
| Range 5 ( $\pm 500 \mathrm{mV}$ ) |  | $\pm 0.005$ | $\pm 0.007$ | \% FSR |  |
| Range 6 ( $\pm 1 \mathrm{~V}$ ) |  | $\pm 0.005$ | $\pm 0.007$ | \% FSR |  |
| Range 7 ( $\pm 2 \mathrm{~V}$ ) |  | $\pm 0.005$ | $\pm 0.007$ | \% FSR |  |
| Range $8( \pm 5 \mathrm{~V}$ ) |  | $\pm 0.007$ | $\pm 0.010$ | \% FSR |  |
| Range $9( \pm 10 \mathrm{~V})$ |  | $\pm 0.005$ | $\pm 0.010$ | \% FSR |  |
| Range A (Type J, $0^{\circ} \mathrm{C}$ to $760^{\circ} \mathrm{C}$ ) |  | $\pm 0.25$ | $\pm 0.45$ | ${ }^{\circ} \mathrm{C}$ | Note 3 (Temperature Ranges) |
| Range B (Type K, $0^{\circ} \mathrm{C}$ to $1000^{\circ} \mathrm{C}$ ) |  | $\pm 0.55$ | $\pm 0.75$ | ${ }^{\circ} \mathrm{C}$ |  |
| Range C (Type T, $-100^{\circ} \mathrm{C}$ to $+400^{\circ} \mathrm{C}$ ) |  | $\pm 0.25$ | $\pm 0.45$ | ${ }^{\circ} \mathrm{C}$ |  |
| Range D (Type E, $0^{\circ} \mathrm{C}$ to $1000^{\circ} \mathrm{C}$ ) |  | $\pm 0.20$ | $\pm 0.35$ | ${ }^{\circ} \mathrm{C}$ |  |
| Range E (Type R, $500^{\circ} \mathrm{C}$ to $1750^{\circ} \mathrm{C}$ ) |  | $\pm 1.00$ | $\pm 1.75$ | ${ }^{\circ} \mathrm{C}$ |  |
| Range F (Type S, $500^{\circ} \mathrm{C}$ to $1750^{\circ} \mathrm{C}$ ) |  | $\pm 1.15$ | $\pm 2.05$ | ${ }^{\circ} \mathrm{C}$ |  |
| Range 10 (Type B, $500^{\circ} \mathrm{C}$ to $1800^{\circ} \mathrm{C}$ ) |  | $\pm 1.15$ | $\pm 2.15$ | ${ }^{\circ} \mathrm{C}$ |  |
| Range 11 (Pt 385, $-200^{\circ} \mathrm{C}$ to $800^{\circ} \mathrm{C}$ ) |  | $\pm 0.20$ | $\pm 0.40$ | ${ }^{\circ} \mathrm{C}$ |  |
| Range $12\left(\mathrm{Pt} 392,-200^{\circ} \mathrm{C}\right.$ to $800^{\circ} \mathrm{C}$ ) |  | $\pm 0.20$ | $\pm 0.40$ | ${ }^{\circ} \mathrm{C}$ |  |
| ACCURACY (ERROR) DRIFT |  |  |  |  |  |
| Range 0 ( $\pm 10 \mathrm{mV}$ ) |  | -40 | -100 | ppm/ ${ }^{\circ} \mathrm{C}$ | Notes 4 and 5 (All Ranges) |
| Range 1 ( $\pm 20 \mathrm{mV}$ ) |  | -20 |  | ppm $/{ }^{\circ} \mathrm{C}$ |  |
| Range 2 ( $\pm 50 \mathrm{mV}$ ) |  | -10 |  | ppm $/{ }^{\circ} \mathrm{C}$ |  |
| Range 3 ( $\pm 100 \mathrm{mV}$ ) |  | -5 |  | ppm $/{ }^{\circ} \mathrm{C}$ |  |
| Range 4 ( $\pm 200 \mathrm{mV}$ ) |  | -5 |  | ppm $/{ }^{\circ} \mathrm{C}$ |  |
| Range 5 ( $\pm 500 \mathrm{mV}$ ) |  | -5 |  | ppm $/{ }^{\circ} \mathrm{C}$ |  |
| Range 6 ( $\pm 1 \mathrm{~V}$ ) |  | -5 |  | ppm $/{ }^{\circ} \mathrm{C}$ |  |
| Range 7 ( $\pm 2 \mathrm{~V}$ ) |  | -5 |  | ppm $/{ }^{\circ} \mathrm{C}$ |  |
| Range 8 ( $\pm 5 \mathrm{~V}$ ) |  | -5 |  | ppm/ $/{ }^{\circ} \mathrm{C}$ |  |
| Range 9 ( $\pm 10 \mathrm{~V}$ ) |  | -5 |  | ppm $/{ }^{\circ} \mathrm{C}$ |  |
| Range A (Type J, $0^{\circ} \mathrm{C}$ to $760^{\circ} \mathrm{C}$ ) |  | -10 |  | ppm $/{ }^{\circ} \mathrm{C}$ |  |
| Range B (Type K, $0^{\circ} \mathrm{C}$ to $1000^{\circ} \mathrm{C}$ ) |  | -10 |  | ppm $/{ }^{\circ} \mathrm{C}$ |  |
| Range C (Type T, $-100^{\circ} \mathrm{C}$ to $+400^{\circ} \mathrm{C}$ ) |  | -20 |  | ppm $/{ }^{\circ} \mathrm{C}$ |  |
| Range D (Type E, $0^{\circ} \mathrm{C}$ to $1000^{\circ} \mathrm{C}$ ) |  | -10 |  | ppm $/{ }^{\circ} \mathrm{C}$ |  |
| Range E (Type R, $500^{\circ} \mathrm{C}$ to $1750^{\circ} \mathrm{C}$ ) |  | -20 |  | ppm $/{ }^{\circ} \mathrm{C}$ |  |
| Range F (Type S, $500^{\circ} \mathrm{C}$ to $1750^{\circ} \mathrm{C}$ ) |  | -40 |  | ppm $/{ }^{\circ} \mathrm{C}$ |  |
| Range 10 (Type B, $500^{\circ} \mathrm{C}$ to $1800^{\circ} \mathrm{C}$ ) |  | -40 |  | ppm $/{ }^{\circ} \mathrm{C}$ |  |
| Range 11 (Pt 385, $-200^{\circ} \mathrm{C}$ to $800^{\circ} \mathrm{C}$ ) |  | $\pm 10$ | $\pm 25$ | ppm $/{ }^{\circ} \mathrm{C}$ | Note 6 (RTD Ranges) |
| Range $12\left(\mathrm{Pt} 392,-200^{\circ} \mathrm{C}\right.$ to $800^{\circ} \mathrm{C}$ ) |  | $\pm 10$ | $\pm 25$ | ppm/ ${ }^{\circ} \mathrm{C}$ |  |
| RESOLUTION |  |  |  |  |  |
| Range 0 ( $\pm 10 \mathrm{mV}$ ) |  | $\pm 0.035$ |  | \% FSR | Notes 2 and 5 (All Ranges) |
| Range $1( \pm 20 \mathrm{mV}$ ) |  | $\pm 0.02$ |  | \% FSR |  |
| Range $2( \pm 50 \mathrm{mV}$ ) |  | $\pm 0.01$ |  | \% FSR |  |
| Range 3 ( $\pm 100 \mathrm{mV}$ ) |  | $\pm 0.004$ |  | \% FSR |  |
| Range 4 ( $\pm 200 \mathrm{mV}$ ) |  | $\pm 0.002$ |  | \% FSR |  |
| Range 5 ( $\pm 500 \mathrm{mV}$ ) |  | $\pm 0.0015$ |  | \% FSR |  |
| Range 6 ( $\pm 1 \mathrm{~V}$ ) |  | $\pm 0.0015$ |  | \% FSR |  |
| Range 7 ( $\pm 2 \mathrm{~V}$ ) |  | $\pm 0.0015$ |  | \% FSR |  |
| Range 8 ( $\pm 5 \mathrm{~V}$ ) |  | $\pm 0.0015$ |  | \% FSR |  |
| Range 9 ( $\pm 10 \mathrm{~V}$ ) |  | $\pm 0.0015$ |  | \% FSR |  |
| Range A (Type J, $0^{\circ} \mathrm{C}$ to $760^{\circ} \mathrm{C}$ ) |  | $\pm 0.15$ |  | ${ }^{\circ} \mathrm{C}$ |  |
| Range B (Type K, $0^{\circ} \mathrm{C}$ to $1000^{\circ} \mathrm{C}$ ) |  | $\pm 0.2$ |  | ${ }^{\circ} \mathrm{C}$ |  |
| Range C (Type T, $-100^{\circ} \mathrm{C}$ to $+400^{\circ} \mathrm{C}$ ) |  | $\pm 0.15$ |  | ${ }^{\circ} \mathrm{C}$ |  |
| Range D (Type E, $0^{\circ} \mathrm{C}$ to $1000^{\circ} \mathrm{C}$ ) |  | $\pm 0.1$ |  | ${ }^{\circ} \mathrm{C}$ |  |
| Range E (Type R, $500^{\circ} \mathrm{C}$ to $1750^{\circ} \mathrm{C}$ ) |  | $\pm 0.55$ |  | ${ }^{\circ} \mathrm{C}$ |  |
| Range F (Type S, $500^{\circ} \mathrm{C}$ to $1750^{\circ} \mathrm{C}$ ) |  | $\pm 0.6$ |  | ${ }^{\circ} \mathrm{C}$ |  |
| Range 10 (Type B, $500^{\circ} \mathrm{C}$ to $1800^{\circ} \mathrm{C}$ ) |  | $\pm 0.7$ |  | ${ }^{\circ} \mathrm{C}$ |  |
| Range $11\left(\mathrm{Pt} 385,-200^{\circ} \mathrm{C}\right.$ to $+800^{\circ} \mathrm{C}$ ) |  | $\pm 0.15$ |  | ${ }^{\circ} \mathrm{C}$ |  |
| Range $12\left(\mathrm{Pt} \mathrm{392}-,200^{\circ} \mathrm{C}\right.$ to $+800^{\circ} \mathrm{C}$ ) |  | $\pm 0.15$ |  | ${ }^{\circ} \mathrm{C}$ |  |


| Parameter | AD1B60BS, AD1B60BJ |  |  | Unit | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max |  |  |
| INPUT CHARACTERISTICS <br> Normal Mode Rejection (@ 50 Hz or 60 Hz ) <br> Input Bias Current <br> Input Impedance <br> Channel 0-3 <br> Attenuator Input | 35 | $\begin{aligned} & 66 \\ & 50 \\ & -0.5 \\ & -0.5 \\ & 10 \\ & 50 \end{aligned}$ | -3 65 | dB <br> dB <br> nA <br> nA <br> M $\Omega$ <br> $\mathrm{k} \Omega$ | At Integration Time $\geq 100 \mathrm{~ms}$ Note 2 $\begin{aligned} & \text { At } \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \text { At }-25^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \end{aligned}$ |
| RTD \& THERMOCOUPLE CHANNELS <br> RTD Excitation Current Output (EXCIT) <br> vs. Temperature <br> Open Thermocouple Detection Current (EXCIT) <br> CJC Excitation Current Output (CJC) | $\begin{aligned} & -150 \\ & -15 \end{aligned}$ | $\begin{aligned} & -200 \\ & \pm 75 \\ & -10 \\ & -20 \end{aligned}$ | $\begin{aligned} & -250 \\ & \pm 300 \\ & -25 \end{aligned}$ | $\mu \mathrm{A}$ <br> ppm $/{ }^{\circ} \mathrm{C}$ <br> nA <br> $\mu \mathrm{A}$ | Note 7; at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ <br> Note 6 <br> Note 8; at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |
| REFERENCE <br> Internal Reference Output Voltage vs. Temperature Internal Reference Voltage Noise Ref In Current | $2.360$ | $\begin{aligned} & 2.500 \\ & \pm 25 \\ & 0.01 \\ & 350 \end{aligned}$ | $\begin{aligned} & 2.640 \\ & \pm 50 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{ppm} /{ }^{\circ \mathrm{C}} \\ & \% \mathrm{p} \mathrm{p} \\ & \mu \mathrm{~A} \end{aligned}$ |  |
| TIMING <br> Conversion Throughput Rate Integration Time (User Configurable) Integration Capacitor Oscillator Frequency Integration Latency CLK-to-DATA Delay, Synchronous Port Minimum CS High Time Reset Input Pulse Width (RESETI) | $\begin{aligned} & 2.5 \\ & 2 \\ & 1 \\ & \\ & 400 \\ & 5 \end{aligned}$ | 2.2 <br> 11.0592 <br> 30 | $\begin{aligned} & 100 \\ & 200 \\ & 3 \\ & 100 \end{aligned}$ | $\begin{aligned} & \text { conv/sec } \\ & \mathrm{ms} \\ & \mathrm{nF} \\ & \mathrm{MHz} \\ & \mu \mathrm{~s} \\ & \mathrm{~ns} \\ & \mu \mathrm{~s} \\ & \mu \mathrm{~s} \end{aligned}$ | Note 9 <br> See Table IV <br> Note 10 <br> Notes 10 and 11 <br> See Figure 2B <br> See Figure 4 <br> See Figure 4 |
| DIGITAL LEVELS <br> Inputs <br> Logic 0 Voltage <br> Logic 1 Voltage (Except RESETI) <br> Logic 1 Voltage (RESETI) <br> Outputs <br> Logic 0 Voltage ( $\mathrm{I}_{\text {SINK }}=1.6 \mathrm{~mA}$ ) <br> Logic 1 Voltage ( $\mathrm{I}_{\text {SOURCE }}=-60 \mu \mathrm{~A}$ ) <br> Input Current (CC, RXD, CH/BR0-1, ACM, PMODE) <br> Logic 0 <br> Logic 1-to-0 Transition <br> Input Current (R/ADD0-4, CLK, CS) <br> Input Pulldown Resistor (RESETI) | 2.0 <br> 0.7* <br> 2.4 <br> 50 | (DIG) + | $0.8$ $0.45$ $\begin{aligned} & -75 \\ & -750 \\ & \pm 10 \\ & 150 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \\ & \mu \mathrm{~A} \\ & \mu \mathrm{~A} \\ & \mu \mathrm{~A} \\ & \mathrm{k} \Omega \end{aligned}$ | At $+25^{\circ} \mathrm{C}$ <br> At $\mathrm{V}_{\text {IN }}=0.45 \mathrm{~V}$ <br> At $\mathrm{V}_{\mathrm{IN}}=2.0 \mathrm{~V}$ <br> At $0.45 \leq \mathrm{V}_{\mathrm{In}} \leq+5 \mathrm{VDIG}$ |
| POWER REQUIREMENTS <br> $+V$ Analog (+5VANA) <br> -V Analog (-5VANA) <br> +V Digital (+5VDIG) <br> Power Supply Rejection Ratio | $\begin{aligned} & 4.75 \\ & -5.25 \\ & 4.75 \end{aligned}$ | $\begin{aligned} & 5.00 \\ & 7 \\ & -5.00 \\ & -7 \\ & 5.00 \\ & 10 \\ & -70 \end{aligned}$ | $\begin{aligned} & 5.25 \\ & 15 \\ & -4.75 \\ & -15 \\ & 5.25 \\ & 30 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~mA} \\ & \mathrm{~V} \\ & \mathrm{~mA} \\ & \mathrm{~V} \\ & \mathrm{~mA} \\ & \mathrm{~dB} \end{aligned}$ | $\begin{aligned} & \mathrm{At}+25^{\circ} \mathrm{C} \\ & \mathrm{At}+5 \mathrm{VANA}=5.0 \mathrm{~V} \\ & \text { At }-5 \mathrm{VANA}=-5.0 \mathrm{~V} \\ & \text { Note } 12 \\ & \mathrm{At}+5 \mathrm{VDIG}=5.0 \mathrm{~V} \end{aligned}$ |
| BROWNOUT DETECTOR <br> $\pm$ V Analog Threshold <br> +V Digital Threshold |  | $\begin{aligned} & \pm 3.9 \\ & 3.5 \end{aligned}$ |  | $\begin{aligned} & \text { V } \\ & \text { V } \end{aligned}$ |  |
| TEMPERATURE RANGE <br> Rated Performance Operating Storage | $\begin{aligned} & -25 \\ & -40 \\ & -40 \end{aligned}$ |  | $\begin{aligned} & +85 \\ & +85 \\ & +85 \end{aligned}$ | $\begin{aligned} & { }^{\circ} \mathrm{C} \\ & { }^{\circ} \mathrm{C} \\ & { }^{\circ} \mathrm{C} \end{aligned}$ |  |

## AD1B60—SPECIFICATIONS

NOTES
${ }^{1}$ Accuracy specifications include factory calibration errors but do not include reference noise. Also, accuracy specifications for thermocouple ranges do not include CJC calculation errors, which depend on the calculation method chosen. To calculate total measurement error, add reference noise expressed as a percentage of the reference voltage to the specified accuracy error. Because reference noise results in a gain error, its effect is a percentage of reading. For example, a measurement made using the $\pm 1 \mathrm{~V}$ input range and a reference with $\pm 0.01 \%$ maximum noise would have a maximum error of $\pm 0.007 \% \mathrm{FSR} \pm 0.01 \%$ of reading. FSR $=$ Full-Scale Range, i.e., span of input values. For thermocouple ranges, also add to the measurement error the values in Table A corresponding to the selected CJC type. For example, a measurement made with a Type J thermocouple, downloaded CJC temperature, and a reference with $\pm 0.01 \%$ maximum noise would have a maximum error of $\pm 0.456^{\circ} \mathrm{C} \pm 0.01 \%$ of reading.
${ }^{2}$ At integration time $\geq 33.3 \mathrm{~ms}$ and equal to an integral number of power-line cycles.
${ }^{3}$ Temperature ranges use the International Practical Temperature Scale of 1968 (IPTS-68). Thermocouple accuracy specifies conformance to NIST Monograph 125. RTD accuracy specifies conformance to JIS C 1604, DIN 43760, and IEC 751.
${ }^{4}$ Errors expressed as ppm (parts per million) of reading.
${ }^{5}$ Excluding reference noise and drift.
${ }^{6}$ RTD measurement drift is digitally compensated to $25 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ of reading (maximum), including effects of reference, excitation current, and gain drift.
${ }^{7}$ RTD measurement accuracy is digitally compensated to values shown on first page of specification table.
${ }^{8}$ CJC excitation current is enabled only when the "Thermistor" CJC mode is selected; see Table V.
${ }^{9}$ Minimum throughput occurs at $\mathrm{T}_{\mathrm{INT}}=200 \mathrm{~ms}$ for any range selection. Maximum throughput occurs at $\mathrm{T}_{\mathrm{INT}}=2 \mathrm{~ms}$ for voltage ranges (ranges 0 through 9) only; see Table IV.
${ }^{10}$ User-supplied.
${ }^{11}$ Specified performance obtained with frequency of $11.0592 \mathrm{MHz} \pm 0.1 \%$.
${ }^{12}-0.2 \mathrm{~V}<(+5$ VANA -+5 VDIG $)<0.5 \mathrm{~V}$ for specified performance.
${ }^{13}$ Typical values are not tested or guaranteed. Operation which is specified without explicit reference to variation in operating conditions may differ as these conditions are altered.

Table A. Maximum Thermocouple CJC Calculation Error

| CJC Calculation | Thermistor |  | $1 \mathrm{mV} / \mathrm{K}$ |  | Downloaded | Disabled |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| CJC Mode | 00 |  | 01 |  | 10 | 11 |
| Thermocouple Type | Ambient Temperature of AD1B60 |  |  |  |  |  |
|  | $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $25^{\circ} \mathrm{C}$ | $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $25^{\circ} \mathrm{C}$ | $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| J | $0.6{ }^{\circ} \mathrm{C}$ | $0.1^{\circ} \mathrm{C}$ | $0.4{ }^{\circ} \mathrm{C}$ | $0.3^{\circ} \mathrm{C}$ | $0.006^{\circ} \mathrm{C}$ | $0^{\circ} \mathrm{C}$ |
| K | $0.6{ }^{\circ} \mathrm{C}$ | $0.1{ }^{\circ} \mathrm{C}$ | $0.4{ }^{\circ} \mathrm{C}$ | $0.3{ }^{\circ} \mathrm{C}$ | $0.012^{\circ} \mathrm{C}$ | $0^{\circ} \mathrm{C}$ |
| T | $0.8{ }^{\circ} \mathrm{C}$ | $0.2^{\circ} \mathrm{C}$ | $0.6{ }^{\circ} \mathrm{C}$ | $0.4{ }^{\circ} \mathrm{C}$ | $0.028^{\circ} \mathrm{C}$ | $0^{\circ} \mathrm{C}$ |
| E | $0.6{ }^{\circ} \mathrm{C}$ | $0.1^{\circ} \mathrm{C}$ | $0.4{ }^{\circ} \mathrm{C}$ | $0.3^{\circ} \mathrm{C}$ | $0.024^{\circ} \mathrm{C}$ | $0^{\circ} \mathrm{C}$ |
| R | $0.4{ }^{\circ} \mathrm{C}$ | $0.1^{\circ} \mathrm{C}$ | $0.3^{\circ} \mathrm{C}$ | $0.2^{\circ} \mathrm{C}$ | $0.007^{\circ} \mathrm{C}$ | $0^{\circ} \mathrm{C}$ |
| S | $0.4{ }^{\circ} \mathrm{C}$ | $0.1{ }^{\circ} \mathrm{C}$ | $0.3{ }^{\circ} \mathrm{C}$ | $0.2{ }^{\circ} \mathrm{C}$ | $0.007^{\circ} \mathrm{C}$ | $0^{\circ} \mathrm{C}$ |
| B | $0.3{ }^{\circ} \mathrm{C}$ | $0.3^{\circ} \mathrm{C}$ | $0.3{ }^{\circ} \mathrm{C}$ | $0.3^{\circ} \mathrm{C}$ | $0.250^{\circ} \mathrm{C}$ | $0^{\circ} \mathrm{C}$ |

## ABSOLUTE MAXIMUM RATINGS*

( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise stated)

| VDIG to DGND | $0.3 \mathrm{~V} \text { to }+6 \mathrm{~V}$ |
| :---: | :---: |
| +5VANA to AGND | 0.3 V to +6 V |
| -5VANA to AGND | -6 V to +0.3 V |
| +5VDIG to +5VANA | 6 V to +0.3 V |
| +5VANA to -5VANA | 0 V to 12 V |
| AGND to DGND | 0.3 V |
| Analog Inputs to AGND (Exc. ATTE | TEN) $. . \pm 5 \mathrm{VANA} \pm 0.3 \mathrm{~V}$ |
| ATTEN Input to AGND | $\pm 15 \mathrm{~V}$ |
| REFOUT, EXCIT to AGND | V to $+5 \mathrm{VANA}+0.3 \mathrm{~V}$ |
| Digital Inputs to DGND | .3 V to $+5 \mathrm{VDIG}+0.3 \mathrm{~V}$ |
| Digital Outputs to DGND . . . . -0. | -0.3 V to $+5 \mathrm{VDIG}+0.3 \mathrm{~V}$ |
| Storage Temperature Range | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Lead Temperature (Soldering, 10 sec ) | sec) . . . . . . . . . . . . $300^{\circ} \mathrm{C}$ |
| Power Dissipation to $75^{\circ} \mathrm{C}$ | ,000 mW |
| Derate Above $+75^{\circ} \mathrm{C}$ by |  |

*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Absolute Maximum Ratings apply individually only, not in combination.

## ORDERING GUIDE

| Model | Temperature Range | Package Option» |
| :--- | :--- | :--- |
| AD1B60BS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{S}-64$ |
| AD1B60BJ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{J}-44$ |
| AD1B60/EB | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Printed Circuit Board |

## NOTES

*S = Plastic Quad Flat Pack (PQFP), J = J-leaded Ceramic Chip Carrier, $/ E B=$ Evaluation Board with AD1B60BJ \& Software. Consult factory for availability. For outline information see Package Information section.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD1B60 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


Table I. Pin Functions

| BS \# | BJ \# | Name | Connection |
| :---: | :---: | :---: | :---: |
| 4 | 18 | RESETI | Reset input; active high. Initializes the AD1B60 to the pin-strapped and EEPROM default values. Connect to RESETO. |
| 5 | 19 | RXD | Receive data input for asynchronous port. |
| 6 | 20 | TXD | Transmit data output for asynchronous port. |
| 7 | 21 | CC | Continuous Conversion input. <br> Enables synchronous signal integration or continuous conversion. While low, the AD1B60 waits in "idle mode." When CC goes high, the AD1B60 starts converting. While held high, the AD1B60 continuously converts input data. |
| 8 | 22 | DGND | Digital ground. |
| 12 | 23 | +5VANA | $+5 \mathrm{~V}, \pm 5 \%$ analog power supply. |
| 13 | 24 | REFOUT | Output from internal reference ( +2.5 V ). |
| 14 | 25 | REFIN | Reference input; may be connected directly to REFOUT. |
| 15 | 26 | -5VANA | $-5 \mathrm{~V}, \pm 5 \%$ analog power supply. |
| 16 | 27 | AGND | Analog ground. |
| 17 | 28 | ATTEN | 5:1 attenuator input for $\pm 5 \mathrm{~V}$ and $\pm 10 \mathrm{~V}$ input voltages. |
| 21 | 29 | C2 | External integration capacitor (nominally 2.2 nF ). |
| 22 | 30 | C1 | External integration capacitor. |
| 23 | 31 | NC | Make no connection (factory test). |
| 24 | 32 | CJC | External CJC sensor input. Also outputs $20 \mu \mathrm{~A}$ excitation current in thermistor CJC mode. |
| 25 | 33 | EXCIT | Excitation Output: provides 10 nA for open thermocouple detection if a thermocouple range is selected, or $200 \mu \mathrm{~A}$ excitation if an RTD range is selected. |
| 26 | 34 | GNDSNS | Sense input for ground potential. Connect to AGND (typical). |
| $\underline{27}$ | 35 | CH3 | Channel 3 signal input. |
| 28 | 36 | CH2 | Channel 2 signal input. |
| 29 | 37 | CH1 | Channel 1 signal input. |
| 30 | 38 | CH0 | Channel 0 signal input. |
| 31 | 39 | NC | Make no connection (factory test). |
| 34 | 40 | RESETO | Output from the power-on reset/brownout detect/watchdog timer circuit; active high. Connect to RESETI. |
| 35 | 41 | +5VDIG | $+5 \mathrm{~V}, \pm 5 \%$ digital power supply; connect also to other +5 VDIG pins. |
| 36 | 42 | CS | Chip select input (low to select). Connect to DGND if not used. |
| 37 | 43 | CLK | Synchronous serial shift clock input. Connect to DGND if not used. |
| 38 | 44 | DATA | Synchronous serial data output. |


| BS \# | BJ \# | Name | Connection |
| :---: | :---: | :---: | :---: |
| 39 | 1 | XTLOUT | External crystal ( 11.0592 MHz ). |
| 40 | 2 | XTLIN | External crystal (11.0592 MHz) or external logic-level clock input. |
| 41 | 3 | +5VANA | $+5 \mathrm{~V}, \pm 5 \%$ analog power supply. |
| 45, 46 | 4, 5 | CH/BR0-1 | Channel select inputs when PMODE is low at reset. Baud rate select inputs when PMODE is high at reset. |
| 47 | 6 | +5VDIG | $+5 \mathrm{~V}, \pm 5 \%$ digital power supply; connect also to other +5 VDIG pins. |
| 53-57 | 7-11 | R/ADD4-0 | Range select inputs if PMODE is low at reset. Address select inputs if PMODE and ACM are high at reset. External pull-ups are required. |
| 58 | 12 | +5VDIG | $+5 \mathrm{~V}, \pm 5 \%$ digital power supply; connect also to other +5 VDIG pins. |
| 59 | 13 | STATUS | Computation status output. If Status is high, results from the previous signal integration are being computed; if STATUS is low, results are available. |
| 60 | 14 | PMODE | Mode select input for $\mathrm{CH} / \mathrm{BR}$ and R/ADDR pins; high or low state sensed at power-up and reset. Specifies whether input range, input channel, device address, and baud rate are determined by external pins or by values in EEPROM. |
| 61 | 15 | ACM | Addressed Communication Mode input. When ACM is high, address and CRC are enabled. |
| 62 | 16 | RDY | Ready (integration status) output. If RDY is high, the AD1B60 is integrating the signal; if RDY is low, the AD1B60 is integrating a background input. |
| 63 | 17 | NC | Make no connection (factory test). |

AD1B60 Pin Assignments



Figure 1. Functional Block Diagram

## FUNCTIONAL DESCRIPTION

The AD1B60 is a complete data acquisition subsystem in a single package which interfaces directly to a sensor and a host processor (see Figure 1). The sensor is applied to one or more of the multiplexer inputs and amplified by the programmable gain amplifier. Excitation currents for RTDs, open thermocouple input detection, and cold junction compensation sensors are provided.
The AD1B60 has an input multiplexer with four channels for low level input signals and one channel with an attenuator for high level inputs. There are also reference and zero inputs, a cold junction compensation channel, and an internal temperature sense channel on the multiplexer. Voltage input ranges are $\pm 10 \mathrm{mV}$ full scale to $\pm 10 \mathrm{~V}$ full scale.
The multiplexer feeds a programmable gain amplifier (PGA), which has a gain range of 1 to 128 . The output of the PGA is applied to an integrating voltage-to-frequency converter, which is resolved by the microprocessor. The microprocessor controls the input multiplexer and PGA alternately selecting an input channel, voltage reference, ground, or other signal channel necessary for an accurate measurement.
For a voltage measurement, the AD1B60 will measure the input voltage, measurement ground and reference voltage, and will calculate the value of the input voltage ratiometrically to the reference and then generate an output value in volts.
For thermocouple measurements, the AD1B60 will also read a cold junction sensor, calculate the required CJC correction voltage, apply it to the voltage reading of the thermocouple, and generate an output in degrees Celsius.

For RTD measurements, the AD1B60 will perform 3- or 4-wire lead resistance compensation, compensate for internal excitation and gain drifts and generate an output in degrees Celsius.

The AD1B60's standard input ranges include the seven NIST thermocouple standards, two platinum RTD ranges, and ten voltage ranges.

In addition, the AD1B60 can use two ranges stored in internal EEPROM. These "custom" ranges are easily created by the user through use of the AD1B60 Custom Range Generation Software included with every Evaluation Board. Several example files, such as a Type N thermocouple range, are also included with the software.

With each conversion, the AD1B60 reports status information, input channel, and an overflow flag. The AD1B60 communicates via one or both of its serial ports: a 2-wire asynchronous I/O port up to 19.2 kbaud, and a 3 -wire synchronous data output port up to 5 Mbps .
The AD1B60 contains a brownout detector and watchdog monitor circuit. If any of the power supplies falls below a threshold, or if the internal microprocessor fails to trigger the watchdog timer, this circuit will generate a reset output.

## CONFIGURABLE PARAMETERS

You can set the following parameters of the AD1B60:

- Device Address
- Baud Rate
- Channel Selection
- Input Range
- Integration Time
- Cold Junction Compensation Mode
- RTD Connection Mode

Depending on the parameter, you can change values in the following ways:

- Execute AD1B60 commands to change values in EEPROM.
- Set specified pins on the AD1B60.
- Execute AD1B60 commands to change values in RAM.

The factory-programmed default values of the configurable parameters are listed in Table II.
If the default values for the device address and baud rate do not match those in your application, you must reset the AD1B60 with the PMODE pin high and the desired device address and baud rate set by AD1B60 pins. Using AD1B60 commands, you can change the EEPROM-based defaults, and then power up the AD1B60 with PMODE low to use the new default values from EEPROM.
The following section describes the configurable parameters. The COMMAND SET section describes the commands used to change parameter settings.
Table II. Configurable Parameters and their Default Values

| Configurable <br> Parameter | Factory Default <br> Value | For Details, <br> See |
| :--- | :--- | :--- |
| Device Address | 0 | Table I |
| Baud Rate | 9600 | Table VII |
| Channel Selection | 0 | Figure 5 |
| Input Range | Type J Thermocouple | Table III |
| Integration Time | 100 ms | Table IV |
| Cold Junction Com- <br> pensation Mode | Direct Connection <br> of a Thermistor <br> RTD Connection Mode <br> 3-Wire | Table V |

## CONFIGURATION PARAMETER DESCRIPTIONS

## Device Address

In Addressed Communication Mode (ACM pin high), you can connect a cluster of up to 32 AD1B60s to a single communication port. Each AD1B60 in a cluster must have a unique address from 0 to 31 ( 0 to 1 F hex).
When the AD1B60 is reset with PMODE high, the address is read from R/ADD 4-0 pins. Refer to Table I for more information on using the pins of the AD1B60.
When the AD1B60 is reset with PMODE low, the address is read from EEPROM. You can change the default address stored in EEPROM by executing the WR_EPM_PARS command.

## Baud Rate

You can set one of the following baud rates for the AD1B60: $2400,4800,9600$ (the factory default), or 19200.
When the AD1B60 is reset with PMODE low, the baud rate is read from EEPROM. You can change the default baud rate stored in EEPROM by executing the WR_EPM_PARS command.
When the AD1B60 is reset with PMODE high, the baud rate is read from the $\mathrm{CH} / \mathrm{BR} 0-1$ pins.

## Channel Selection

Although the AD1B60 is optimized for single-channel applications, you can use up to five input channels on one device. The AD1B60 checks the input channel selection before each conversion. Note that selecting an RTD or high voltage input range also determines the channel(s).
If the AD1B60 is powered up with PMODE high, Channel 0 is selected. For thermocouple and low level voltage ranges, you can select an input channel using the SEL_CH command. Check the channel address in the ADSTAT byte returned with the data to ensure that the data represents the correct channel. Also
check ADSTAT's Valid Data flag after changing channels. You may have to wait up to two integration times for valid data when changing channels on the same input range. Refer to the COMMAND SET section for more information on SEL_CH.
If the AD1B60 is reset with PMODE low, the input channel is determined by the CH/BR 0-1 pins.

## Input Ranges

The AD1B60 supports the input ranges listed in Table III.
If the standard input ranges (numbered 00 through 12 hex) do not meet the requirements of your application, you can download up to two additional user defined custom input ranges into the AD1B60. Custom ranges are generated by the user with the Custom Range Generation Software. Refer to the following subsection for more information on downloading input ranges.
The input range is determined by the R/ADD $4-0$ pins when the AD1B60 is reset with PMODE low.

Table III. Input Ranges

| Input Range | Range Code <br> (In Hex) |
| :--- | :--- |
| $\pm 10 \mathrm{mV}$ | 00 |
| $\pm 20 \mathrm{mV}$ | 01 |
| $\pm 50 \mathrm{mV}$ | 02 |
| $\pm 100 \mathrm{mV}$ | 03 |
| $\pm 200 \mathrm{mV}$ | 04 |
| $\pm 500 \mathrm{mV}$ | 05 |
| $\pm 1 \mathrm{~V}$ | 06 |
| $\pm 2 \mathrm{~V}$ | 07 |
| $\pm 5 \mathrm{~V}$ (ATTEN Input) | 08 |
| $\pm 10 \mathrm{~V}$ (ATTEN Input) | 09 |
| Type J Thermocouple, $0^{\circ} \mathrm{C}$ to $760^{\circ} \mathrm{C} \star$ | 0 A |
| Type K Thermocouple, $0^{\circ} \mathrm{C}$ to $1000^{\circ} \mathrm{C}$ | 0 B |
| Type T Thermocouple, $-100^{\circ} \mathrm{C}$ to $+^{\circ} 400^{\circ} \mathrm{C}$ | 0 C |
| Type E Thermocouple, $0^{\circ} \mathrm{C}$ to $1000^{\circ} \mathrm{C}$ | 0 D |
| Type R Thermocouple, $500^{\circ} \mathrm{C}$ to $1750^{\circ} \mathrm{C}$ | 0 E |
| Type S Thermocouple, $500^{\circ} \mathrm{C}$ to $1750^{\circ} \mathrm{C}$ | 0 F |
| Type B Thermocouple, $500^{\circ} \mathrm{C}$ to $1800^{\circ} \mathrm{C}$ | 10 |
| Platinum RTD, $100 \Omega, \alpha=0.00385$, | 11 |
| $-200^{\circ} \mathrm{C}$ to $+800^{\circ} \mathrm{C}$ |  |
| Platinum RTD, $100 \Omega, \alpha=0.00392$, | 12 |
| $-200^{\circ} \mathrm{C}$ to $+800^{\circ} \mathrm{C}$ |  |
| Not Used | 13 to 1 D |
| User Range 1 | 1 E |
| User Range 2 | 1 F |
|  |  |

## NOTE

*Default Configuration
The input range is read from EEPROM when the AD1B60 is reset with PMODE high. To change the input range stored in EEPROM, execute the WR_EPM_PARS command. You can also change the input range by using the WR_RAM_PARS command. This command changes the range immediately and does not affect values in EEPROM. You can issue the RD_RAM_PARS command to read the current configuration.

You can use only one input range at a time. When you change the input range, you may have to wait up to 13 integration times to ensure that the output data is valid, as indicated by the Valid Data flag in the ADSTAT byte. Therefore, you should only change the input range in applications having very low bandwidth.

## AD1B60

## Downloading User Input Ranges

You can choose up to two additional user defined input ranges to download into the AD1B60's EEPROM at any time. A range is typically generated by a user in order to accept a sensor or input signal not supported by the standard AD1B60 internal ranges or to provide a range that optimizes the output data for easier calculations or other considerations.

Ranges can be simply made by using the IBM PC compatible, Windows version "AD1B60 Custom Range Generation Software." All AD1B60 software is included free of charge with each Evaluation Board.
To download an input range to EEPROM, execute the LOAD_RNG command. You must execute LOAD_RNG eight times to download the entire input range to EEPROM. Refer to the COMMAND SET section for more information on this command.

## Reading User-Downloaded Input Ranges

To verify a user-downloaded input range, execute the GET_RNG command. You must execute GET_RNG eight times to read the entire input range from EEPROM.

## Integration Time

You can set the integration time used by the AD1B60's A/D converter. The integration time and the input range affect the overall conversion rate. Table IV shows available integration times and the range of corresponding conversion rates, as well as line frequencies that have high normal mode rejection (NMR). Voltage ranges have the fastest conversion rates. Because of the extensive calculation required for linearization and compensation, the conversion rate for Type K thermocouples is the slowest of the AD1B60's standard ranges.

Setting the integration time equal in duration to an integral number of power line cycles will cause high normal mode rejection at the line frequency. The fastest available integration times for 50 Hz and 60 Hz are 40 ms and 33.3 ms , respectively; each time is equal to two power line cycles. The default integration time, 100 ms , is an integral multiple of both power line periods.
You can change the default integration time stored in EEPROM by executing the WR_EPM_PARS command. You can change the integration time without changing values in EEPROM by executing
the WR_RAM_PARS command. You can use the RD_RAM_PARS command to read back the current configuration.

## Cold Junction Compensation Mode

The AD1B60 provides four different CJC modes for thermocouple ranges, described in Table V.
You can change the default CJC mode stored in EEPROM by executing the WR_EPM_PARS command.

You can change the CJC mode without changing the EEPROM default by executing the WR_RAM_PARS command. To read the current CJC mode from RAM, execute the RD_RAM_PARS command. To read the current value of the CJC temperature from RAM, execute the RD_CJC command.

## RTD Connection Mode

The AD1B60 supports 3-wire and 4 -wire RTD connection modes (see Figures 10, 11, and 12); 3 -wire is the default configuration.
You can change the default RTD connection mode stored in EEPROM by executing the WR_EPM_PARS command.
You can change the RTD connection mode without changing the EEPROM default by executing the WR_RAM_PARS command. To read back the current configuration stored in RAM, execute the RD_RAM_PARS command.

Table IV. Integration Times

| Integration <br> Time | Conversion <br> Rate | High NMR <br> Frequency | AUX Byte <br> Bits B2-B0 |
| :--- | :--- | :--- | :--- |
| 200 ms | 2.5 per second | 50 or 60 Hz | 000 |
| $100^{\star}$ | $5 \star$ | 50 or 60 | $001^{\star}$ |
| 60 | 8.3 | 50 | 010 |
| 50 | 9.9 | 60 | 011 |
| 40 | 12.3 | 50 | 100 |
| 33.3 | 14.8 | 60 | 101 |
| 5 | $44 \dagger$ to $87.5 \ddagger$ |  | 110 |
| 2 | $48 \dagger$ to $100 \ddagger$ |  | 111 |

NOTES
*Default Configuration
$\dagger$ Type K thermocouple with thermistor CJC (mode 00)
$\ddagger$ Voltage range with CJC disabled (Mode 11)

Table V. Cold Junction Compensation Modes

| CJC <br> Sensor <br> Type | CJC Mode <br> Description | CJC <br> Excitation <br> Current | Cold Junction <br> Temperature <br> Range | AUX Byte <br> Code, <br> Bits B6-B5 |
| :--- | :--- | :--- | :--- | :--- |
| Thermistor* | Direct connection of a 10 K 3 A 1 thermistor made by Betatherm (Shrewsbury, <br> Massachusetts, and Galway, Ireland). At $+25^{\circ} \mathrm{C}$, this thermistor's $\mathrm{R}=10 \mathrm{k} \Omega$, <br> alpha $=-4.4 \% /^{\circ} \mathrm{C}$, and beta $=3892$. | Enabled | $-25^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $00^{\star}$ |
| $1 \mathrm{mV} / \mathrm{K}$ | A $1 \mathrm{mV} / \mathrm{K}$ external sensor is connected at the input. This mode allows the use <br> of silicon sensors, such as the Analog Devices AD592 with a $1 \mathrm{k} \Omega$ resistor <br> (see Figure 9). | Disabled | $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 01 |
| Downloaded | A user-defined value of an externally derived cold junction temperature is <br> downloaded over the asynchronous communication port using the WR CJC <br> command. | Disabled | $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 10 |
| CJC <br> Calculation <br> Disabled | No CJC calculations are performed by the AD1B60. An analog CJC, such as <br> the Analog Devices AC1226, is connected at the input. This type of sensor <br> must be externally configured for the specific thermocouple type. | Disabled | User-defined; <br> must be in $-25^{\circ} \mathrm{C}$ <br> to $+85^{\circ} \mathrm{C} \mathrm{range}$ | 11 |

## NOTE

*Default Configuration

## CONVERSION TIMING AND CONTROL

In normal operation, the Continuous Conversion (CC) Pin is high, and the AD1B60 performs continuous conversions, alternating between signal conversions and background conversions, such as autozero or cold junction compensation (see Figure 2a).
The RDY pin and the Ready flag in the ADSTAT byte are high while the AD1B60 integrates the input signal. The STATUS pin and Status flag in the ADSTAT byte are high while the AD1B60 computes the result of the signal integration. When STATUS goes low, the data is available at the Asynchronous Communication Port. When RDY goes high again for the next signal integration, the data from the prior conversion is available at the Synchronous Data Output Port.
When CC is low, signal conversions are suspended. After CC goes high, a signal conversion will start. This allows synchronizing the conversions to external events, or synchronizing multiple AD1B60s (see Figure 2b). If you communicate with the AD1B60 using the Asynchronous Communications Port, the time spent in communications service may increase the latency between the trigger and the signal conversion.


Figure 2a. Continuous Conversion


Figure 2b. Synchronizing Conversion

## SERIAL COMMUNICATION PORTS

## Asynchronous Communication Port

The asynchronous communication port is a two-wire, halfduplex, input/output port. You can connect the asynchronous port to host systems either at +5 V logic levels or by using external level translation to communication standards such as RS-232 and RS-422. The AD1B60 responds to the commands listed in the COMMAND SET section.

The asynchronous port operates at $2400,4800,9600$, or 19200 baud using eight data bits, no parity, and one stop bit. Bytes are transmitted least significant bit first.

In Addressed Communications Mode (ACM), the asynchronous port supports device addressing and CRC error checking. Device addressing enables clusters of up to 32 AD1B60s to share a single communication line (see Figure 3). Cyclic Redundancy Codes (CRC) improve communication reliability in noisy environments. The AD1B60 uses CRC-16 ( $\mathrm{x}^{16}+\mathrm{x}^{15}+\mathrm{x}^{2}+1$ ) as a generator polynomial.
ACM is active when the ACM pin is high. When ACM is active, the address and CRC are required to accompany commands to the AD1B60, which will include address and CRC in its response. See the COMMAND PARAMETERS section for details on the format of address and CRC. The address and baud rate are read from either EEPROM or external pins at reset, depending on the state of the PMODE pin.

When the PMODE pin is low at reset, device address and async port baud rate are read from EEPROM, and input range and channel are read from R/ADD and $\mathrm{CH} / \mathrm{BR}$ pins at reset. When PMODE is high at reset, address and baud rate are read from these pins, input range is read from EEPROM, and input channel is set to 0 .


Figure 3. Connecting a Cluster of AD1B60s to a Communication Port

If you intend to use the AD1B60 with a device address or baud rate different from the values in EEPROM, reset the device with PMODE high and the desired address and baud rate selected through the R/ADD and $\mathrm{CH} / \mathrm{BR}$ pins. You may then load the desired values of device address and baud rate into EEPROM to free these pins for selecting input range and channel.

If a message with an invalid address, command code, or CRC is received by an AD1B60, it will not respond to that message. The host may use a time-out to detect an AD1B60 that does not respond. If the host detects an error from an AD1B60, whether by invalid response or lack of response, it may issue a Break and retry the command.
The AD1B60 will detect Breaks to allow recovery from communications errors. The AD1B60 recognizes a Break when it receives a character with a zero (space) where the stop bit should be. The AD1B60 then resets its communications processes, and is ready to receive the next command. All AD1B60s on a line will recognize a Break.

## AD1B60

Asynchronous communications with the AD1B60 are halfduplex. If a character is sent to an AD1B60 while it is transmitting, it ignores the character and continues transmitting. After its transmission is complete, the AD1B60 is ready to receive the next character.

## Synchronous Data Output Port

The synchronous port is a 3-wire data output port. It is independent of the asynchronous port, and both can be accessed simultaneously, if desired.

Using the CS (chip select), CLK (clock input), and DATA (data output) pins of the AD1B60, you can read data at speeds up to 5 Mbps (see Figure 4). When RDY goes high at the beginning of a conversion cycle, the MSB of the previous data word appears at the DATA output (see Figures 2a and 2b). Bringing CS low freezes the data in the synchronous port buffer. Results of other conversions won't be transferred to the synchronous port buffer while CS is low. 15 CLK pulses will read out the remaining bits of the word in the synchronous port buffer. Further CLK pulses will continue to read out the same data bits from this circular buffer.

After all 16 bits are read, CS must be brought high and then low again to read the next word. CS must stay high for a minimum of $400 \mu$ s to allow the data buffer to be updated.

The synchronous port sends integer data only, in 16-bit twos complement or offset binary format, depending on the input range (see Table VI).
If you don't use the synchronous output port, ground the CS and CLK pins to minimize digital noise.


Figure 4. Reading Data from the Synchronous Port
Table VI. Integer Data Output Formats

| Voltage Ranges <br> (Twos Complement, in Hex) |  | Temperature Ranges <br> (Offset Binary, in Hex) |  |
| :--- | :--- | :--- | :---: |
| +Full Scale | 7FFF | Top of Span | FFFF |
| Zero | 0000 |  |  |
| Zero -1 LSB | FFFF |  |  |
| -Full Scale | 8000 | Bottom of Span | 0000 |

## COMMAND PARAMETERS

This section describes the parameters of the AD1B60 commands, which are described in the next section. All values in <angle brackets> and [square brackets] are 8-bit bytes; values in [square brackets] are used only when ACM is active. Numbers followed by H are expressed in hexadecimal (hex) notation.
[Addr] represents the address of the AD1B60. It is required in the command and generated in the response only if ACM is active. Values for [addr] range from 00 H to $1 \mathrm{FH}(0$ to 31 deci$\mathrm{mal})$. The factory default value is 00 H .
<ADSTAT>, shown in Figure 5, represents the status of the AD1B60. Values of ADSTAT range from 00 H to FFH. ADSTAT's Valid Data flag and Input Channel should be checked on every measurement reading.
<Aux>, shown in Figure 6, represents the RTD connection mode, CJC mode, and integration time of the AD1B60. Values of <aux> range from 00 H to FFH and may be read via the RD_RAM_PARS command.


Figure 5. The ADSTAT Byte


Figure 6. The Aux Byte

Table VII. Baud Rate Codes

| Baud Rate | Baud Code (in Hex) |
| :--- | :--- |
| 2400 | 00 |
| 4800 | 01 |
| $9600^{\star}$ | $02^{\star}$ |
| 19200 | 03 |

NOTE
*Default Configuration
$<$ Baud $>$ represents the baud rate code of the AD1B60. Table VII lists the codes associated the available baud rates.
$<\mathrm{C} 0>$ through $<\mathrm{C} 3>$ are four bytes that represent the CJC temperature, in ANSI/IEEE 754-single-precision floating-point format, and in degrees C . Values ranges from $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. For example, in this format, a $25^{\circ} \mathrm{C}$ is expressed as 41 C 80000 (hexadecimal). $\langle\mathrm{C} 0\rangle$ contains the least significant byte of the mantissa, or 00 H in this example; $<\mathrm{C} 3>$ contains the sign bit and the 7 most significant bits of the exponent, or 41 H in this example.
[CRC1] and [CRC2] represent the CRC-16 error checking value. These arguments are required in the command and generated in the response only if ACM is active. [CRC1] is the LSB; [CRC2] is the MSB.
$<$ Device_addr> represents the new default address for the AD1B60. Values for <device_addr> range from 00H to 1FH (0 to 31 decimal).
$<$ D0 $>$ through $<$ D7 $>$ comprise an 8 -byte segment of the userselected input range in EEPROM. $\angle \mathrm{D} 0\rangle$ is the low order byte; $<$ D7> is the high order byte.
$<$ F0 $>$ through $<$ F3 $>$ are four bytes that represent the floatingpoint data, in IEEE 754 standard format. See the description of $<\mathrm{C} 0>$ through $<\mathrm{C} 3>$, above, for information on this format.
$<$ INT_LO> and <INT_HI> represent the lower and upper eight bits, respectively, of the 16-bit integer representation of the data. Values range from 00 H to FFH ; see Table VI for data formats.
$<$ Range $>$ represents the input range code. Refer to Table III for a list of the available input range codes. The current range may be read via the RD_RAMPARS command.
$<$ Range_addr> represents the address of the 8 -byte segment of the 64 -byte input range in EEPROM. Range addresses 00 H to 07 H correspond to the eight, 8 -byte segments of User Range 1 (code 1 EH ); range addresses 08 H to 0 FH correspond to the eight, 8 -byte segments of User Range 2 (code 1 FH ).

## COMMAND SET

The AD1B60 commands allow you to configure the AD1B60, read converted data and status information, and calibrate input ranges over the asynchronous port. This section describes the commands in detail.

## Configuration Commands

The AD1B60 Command Set provides the configuration commands listed below. Note that the data written into RAM by WR_RAM_PARS, WR_CJC, and SEL_CH will be cleared at power-up and reset.

## - RD_RAM_PARS

Reads back the current value of the configuration parameters from RAM.

Command Syntax
[addr] $<02 \mathrm{H}>$ [CRC1] [CRC2]
Response Syntax
[addr] <02H> <range> <aux> [CRC1] [CRC2]

## - WR_RAM_PARS

Writes new values of the configuration parameters in RAM. These values take effect immediately and do not change the default values in EEPROM.

Command Syntax
[addr] <04H> <range> <aux> [CRC1] [CRC2]
Response Syntax
[addr] <04H $>$ [CRC1] [CRC2]

## - WR_EPM_PARS

Writes new values of the configuration parameters in EEPROM. The new values do not change currently selected values in RAM and only take effect when the AD1B60 is powered up or reset.
Command Syntax
[addr] <05H> <range> <aux> <device-addr> <baud> [CRC1] [CRC2]

## Response Syntax

[addr] $<05 \mathrm{H}>$ [CRC1] [CRC2]

## - GET_RNG

Reads an 8-byte segment of a downloadable input range from EEPROM. See LOAD_RNG, below.

Command Syntax
[addr] $<07 \mathrm{H}><$ range-addr $>$ [CRC1] [CRC2]
Response Syntax
[addr] $<07 \mathrm{H}\rangle<$ D0 $><$ D1 $><$ D2 $><$ D3 $><$ D4 $><$ D5 $>$
$<$ D6> < D7 > [CRC1] [CRC2]

## - LOAD_RNG

Writes an 8 -byte segment of a downloadable input range into EEPROM. LOAD_RNG and GET_RNG must be executed 8 times to write or read an entire 64-byte range. Each successive time, <range-addr> must increment by 1 to address the next segment.
Command Syntax
[addr] $<08 \mathrm{H}><$ range-addr> <D0> <D1> <D2> <D3>
<D4> <D5> <D6> <D7> [CRC1] [CRC2]

## Response Syntax

[addr] $<08 \mathrm{H}>$ [CRC1] [CRC2]

## AD1860

## - RD_CJC

Reads the current value of the CJC temperature in RAM, in ${ }^{\circ} \mathrm{C}$. This value may have been measured by a thermistor or $\mathrm{mV} / \mathrm{K}$ sensor, or loaded via a WR_CJC command.

## Command Syntax

[addr] $<03 \mathrm{H}>$ [CRC1] [CRC2]
Response Syntax
[addr] $<03 \mathrm{H}><\mathrm{C} 0><\mathrm{C} 1><\mathrm{C} 2><\mathrm{C} 3>$ [CRC1] [CRC2]

## - WR_CJC

Downloads to RAM a CJC temperature in ${ }^{\circ} \mathrm{C}$, obtained from an external source. Only used in Downloaded CJC mode (mode 10).

Command Syntax
[addr] $<06 \mathrm{H}><\mathrm{C} 0><\mathrm{Cl}><\mathrm{C} 2><\mathrm{C} 3>$ [CRC1] [CRC2]
Response Syntax
[addr] $<06 \mathrm{H}>$ [CRC1] [CRC2]

## - SEL_CH

Selects an input channel on the AD1B60 and stores the channel address in RAM. This command is not meaningful if the
PMODE pin is low, or if the input range is RTD or attenuator; for these ranges, the channel is selected automatically.

Command Syntax
[addr] <0AH> <chan> [CRC1] [CRC2]
Response Syntax
[addr] <0AH> <chan> [CRC1] [CRC2]

## Read Data Commands

The AD1B60 Command Set includes the following read data commands:

## - RD_INTDATA

Reads converted data, in 16-bit integer format (see Table VI), and the conversion status.

Command Syntax
[addr] $<00 \mathrm{H}>$ [CRC1] [CRC2]
Response Syntax
[addr] $<00 \mathrm{H}><$ INT_LO $><$ INT_HI $><$ ADSTAT $>$ [CRCl]
[CRC2]

## - RD_FPDATA

Reads converted data, in IEEE 754 floating point format and engineering units, and the conversion status.

Command Syntax
[addr] $<01 \mathrm{H}>$ [CRC1] [CRC2]
Response Syntax
[addr] $<01 \mathrm{H}><\mathrm{F} 0><\mathrm{F} 1><\mathrm{F} 2><\mathrm{F} 3><$ ADSTAT $>$ [CRC1] [CRC2]

## Calibration Command

- CAL

Performs a calibration cycle for parameters related to the configured input range. See the Calibration section below.

## Command Syntax

[addr] $<09 \mathrm{H}><09 \mathrm{H}>$ [CRC1] [CRC2]
Response Syntax
[addr] $<09 \mathrm{H}><09 \mathrm{H}>$ [CRC1] [CRC2]

## CALIBRATION

The AD1B60 is calibrated with its internal reference at the factory prior to shipment. You can also calibrate the AD1B60 in your application, if desired. You should calibrate the AD1B60 if you use an external reference.
Calibrating the AD1B60 requires a precision reference excitation source for different input ranges. The accuracy of the AD1B60 depends on the accuracy of the calibration source. For best performance, calibrate the AD1B60 using the maximum integration time of 200 ms .

Note that calibrating certain input ranges, such as thermocouple ranges, depends on the prior calibration of one or more voltage ranges. Therefore, to properly calibrate all the input ranges and channels of the AD1B60, perform the following procedure for each step of the calibration sequence:

1. Using the WR_RAM_PARS command, configure the AD1B60 for the appropriate range listed in Table VIII. For example, in the first step of the calibration sequence, set the input range to $\pm 2 \mathrm{~V}$.
2. Apply the reference excitation specified for the input range, listed in Table VIII. For example, in the first step of the calibration sequence, apply a +2.00000 V excitation to channel 0 .
3. Issue RD_FPDATA or RD_INTDATA commands and observe the readings. Allow the excitation source to stabilize, and check that the Valid Data flag in the ADSTAT byte is high.
4. Execute the CAL command.
5. Wait until the CAL flag in ADSTAT goes low.
6. Repeat operations 1 through 5 above, using the input ranges and reference excitations, listed in Table VIII, for the next step of the calibration sequence.
Note that you must complete Steps 1 through 8 in Table VIII. However, if your application does not require the attenuator input, you can skip Step 9. If your application does not require thermocouples, you can skip Step 10. If your application does not require RTDs, you can skip Step 11.

## RESETTING THE AD1B60

The AD1B60 generates a reset signal (RESETO) at power-up, on detecting a low supply voltage (brown-out), or on missing an internal watchdog pulse. In normal operation, RESETO is tied to the reset input (RESETI). An external active-high reset signal may be used instead of, or in addition to, RESETO. Figure 7 shows how to OR internal and external signals to control RESETI.


Figure 7. Resetting the AD1B60

Table VIII. Input Ranges and Reference Excitations for Each Iteration of the Calibration Sequence

| Step | Input Range | Range Code | Reference Excitation | Channel to Which Reference <br> Excitation Is Applied |
| :--- | :--- | :--- | :--- | :--- |
| 1 | $\pm 2 \mathrm{~V}$ | 07 | +2.00000 V | CH0 to Analog Gnd <br> 2 |
| $\pm 1 \mathrm{~V}$ | 06 | +1.00000 V | CH0 to Analog Gnd |  |
| 3 | $\pm 500 \mathrm{mV}$ | 05 | +0.50000 V | CH0 to Analog Gnd |
| 4 | $\pm 200 \mathrm{mV}$ | 04 | +0.20000 V | CH0 to Analog Gnd |
| 5 | $\pm 100 \mathrm{mV}$ | 03 | +0.10000 V | CH0 to Analog Gnd |
| 6 | $\pm 50 \mathrm{mV}$ | +50.000 mV | CH0 to Analog Gnd |  |
| 7 | $\pm 20 \mathrm{mV}$ | +20.000 mV | CH0 to Analog Gnd Gnd |  |
| 8 | $\pm 10 \mathrm{mV}$ | 02 | +10.000 mV | Attenuator Input to Analog Gnd |
| 9 | $\pm 10 \mathrm{~V}$ | 01 | CJC Input to Analog Gnd |  |
| 10 | Type J Thermocouple | 09 | $250 \Omega$ Reference Resistor Substituted |  |
| 11 | $100 \Omega$ Pt. RTD, | 11 | $250.00000 \mathrm{~V} \Omega$ | for 4-Wire RTD (See Figure 10) |
|  | $\alpha=0.00385$ |  |  |  |

## TYPICAL INPUT CONNECTIONS

## Thermocouple Input Connections

Figure 8 shows the AD1B60 connections required for a typical, single thermocouple input. In this example, a thermistor CJC sensor is used; the AD1B60 provides the CJC sensor excitation current. The EXCIT output can be used to source current, nominally 10 nA , for open-circuit detection.
Figure 9 shows how four thermocouples may be connected, using a $1 \mathrm{mV} / \mathrm{K} \mathrm{CJC} \mathrm{sensor}$. share a common ground.


Figure 8. Typical Single-Channel Thermocouple Connection (with Thermistor CJC)


Figure 9. Typical Four-Channel Thermocouple Connection (with AD592 CJC)

## Using the CJC Pin as a Digital Output

The CJC pin is normally used as an analog input for coldjunction compensation of thermocouples. When thermistor CJC mode is selected, this pin also outputs an excitation current (nominally $20 \mu \mathrm{~A}$ ) for the CJC sensor. In other CJC modes, this output is switched off.
If thermocouples are not being used, the CJC pin may serve as a digital output. This may be especially useful if the AD1B60 is isolated, since providing an isolated control line by other means would be costly.
By placing a $330 \mathrm{k} \Omega$ resistor to AGND from this pin, a logic voltage can be generated (see Figure 11). The level can be switched from high (about +4 V ) to low (AGND) by changing the CJC mode from thermistor (00) to any other, using the WR_RAM_PARS command.

## RTD Input Connections

Typical 3-wire and 4-wire RTD input connections are shown in
Figure 10. The EXCIT output supplies $200 \mu \mathrm{~A}$ excitation to the RTD. To maintain high accuracy, lead resistances must match and be less than $20 \Omega$ for 3 -wire RTDs, and must be less than $40 \Omega$ for 4 -wire RTDs. The $10 \mathrm{k} \Omega$ resistor in series with the excitation current source is not required, but will reduce power dissipation and self-heating errors in the AD1B60.
Two RTDs can be multiplexed using the CJC pin as a control line to select between them, as described in the previous subsection. Figures 11 and 12 show multiplexed 3 -wire and 4 -wire RTDs.


Figure 10. Typical Single-Channel RTD Connection


Figure 11. Typical Multiplexed 3-Wire RTD Connection


Figure 12. Typical Multiplexed 4-Wire RTD Connection

## Low Level Voltage Input Connections

Single channel input connections for low level voltages of up to $\pm 2 \mathrm{~V}$ are similar to those of thermocouple input connections, except that no CJC sensor is required. When connecting multiple-channel, low level voltage inputs, all four inputs must share a common ground, as shown in Figure 13. For fastest response when switching between channels, all inputs must share the same input range.

## High Level Voltage Input Connections

High level voltages must be connected to the Attenuator pin. An internal 5:1 attenuator scales down high level voltage inputs of $\pm 5 \mathrm{~V}$ or $\pm 10 \mathrm{~V}$ to levels compatible with the AD1B60's frontend circuitry. Figure 14 shows a typical connection for a high level voltage input.

## Input Protection

Inputs that are subject to large transient voltages require protection. For example, inputs should be protected if they connect to sensors through several hundred feet of wiring that may pick up electrical noise or if they may be connected accidentally to power lines. Such inputs should use series resistors to limit input currents and diodes to clamp transient voltages (see Figure 15).
The EXCIT, CH0-CH3, and GNDSNS pins may be subject to large transients and hence may require protection. The ATTEN


Figure 13. Typical Multiple-Channel Low Level Voltage Input


Figure 14. Typical High Level Voltage Input Connection
pin has an internal $40 \mathrm{k} \Omega$ resistor, and does not require an external resistor; however, clamp diodes may be required. Generally, the CJC, AGND, and other pins are connected only locally and don't require protection.
Any mismatch in input resistance between an input channel and GNDSNS will be multiplied by the input bias current ( 3 nA max) and create an apparent input offset voltage. For example, $50 \mathrm{k} \Omega, 1 \%$ resistors may mismatch by as much as $1 \mathrm{k} \Omega$, resulting in a $3 \mu \mathrm{~V}$ input offset. The resistor used to protect the EXCIT pin may be much larger, since the thermocouple opencircuit detection current is only 10 nA . A $1 \mathrm{M} \Omega$ resistor will cause a drop of 10 mV .


Figure 15. Typical Input Protection Circuitry

The AD1B60 side of the resistors must be clamped to suitable voltages, such as the supply rails (see the Absolute Maximum Ratings). Use low leakage, low capacitance diodes, such as diode-connected J201 JFETs. Note that the diodes' leakage current will flow through the protection resistors and create an offset voltage.
The resistors must be able to withstand the worst-case expected fault voltage, the clamp diodes must be able to pass the worstcase fault current, and the clamp voltages (e.g., the power supplies) must be able to absorb the fault current.
For a fully protected system, you must isolate the AD1B60 from ground. You may do so by using optoisolators on the communications port (RXD and TXD pins) and a dc-to-dc converter for the power supplies.

## GENERAL CIRCUIT CONSIDERATIONS

In any system including logic and low level analog signals, care
must be taken in the layout and bypassing of the components. Bypass the analog and digital supplies close to the package pins, with a $1: 0 \mu \mathrm{~F}$ or $4.7 \mu \mathrm{~F}$ tantalum capacitor in parallel with a $0.1 \mu \mathrm{~F}$ ceramic capacitor. Keep analog and digital grounds separate except at a single common point. Minimize stray capacitance between digital signals and any analog signal, including analog common. All analog grounds should be connected in a star pattern to a single point.

The integrating capacitor, $\mathrm{C}_{\text {INT }}$, should be ceramic and of good quality (X7R dielectric or better). If the synchronous output port is not used, connect CS and CLK to DGND to minimize digital noise.

Figure 16 shows a typical hookup for the default configuration parameters: Type J thermocouple with thermistor CJC and device address 0 . The AD232 translates between the TTL levels of the AD1B60 and RS-232 levels for the asynchronous I/O port.


Figure 16. Typical Input and Output Connections for Thermocouple Application

## EVALUATION BOARD

The AD1B60/EB evaluation board contains an AD1B60 and support circuitry which allows you to evaluate its functionality and performance using an IBM PC via an asynchronous RS-232 communications port (COM1 or COM2 only).
Included with the evaluation board is an AD1B60BJ device, Evaluation Board User's Manual, 3.5" diskette with the AD1B60 Demonstration Program for PC-DOS and a free copy of the AD1B60 Custom Range Generation Software for Windows.

The menu-driven Demonstration Program allows you to configure and read data from the AD1B60. The Custom Range Generation Software allows generation of user defined ranges specific to your application without additional assistance required from Analog Devices. These range files may be downloaded into the EEPROM of the AD1B60 as required to optimize its performance in your specific application.

```
PRODUCT FEATURES
Single Package
16-Bit Resolution
500 kHz Sampling Rate
SNR 90 dB @ 100 kHz (min)
THD -88 dB @ 100 kHz (min)
0.0015\% FSR INL (typ)
\(\pm 5, \pm 10 \mathrm{~V}\) Bipolar Input
Zero Offset Autocalibration
APPLICATIONS
Medical Imaging CAT
Magnetic Resonance
Vibration Analysis
Parametric Measurement Unit (ATE)
Waveform/Transient Recorders
Analytical Instruments
Sonar
Radar
```


## PRODUCT DESCRIPTION

The AD1382 is a complete $500 \mathrm{kHz}, 16$-bit, sampling analog-to-digital converter contained in a single package. This high resolution, high speed converter offers outstanding noise and distortion performance along with excellent INL and DNL performance, all in a single dual-in-line package.
The AD1382 guarantees outstanding noise and distortion performance for both $\pm 5 \mathrm{~V}$ and $\pm 10 \mathrm{~V}$ input ranges. The AD1382 architecture includes a low noise and low distortion track/hold with a three-pass digitally corrected subranging ADC. Precision thin film resistors and a new proprietary DAC provide for outstanding dynamic and static performance. Output data is multiplexed over an eight-bit CMOS/TTL compatible data bus.

FUNCTIONAL BLOCK DIAGRAM


The AD1382 uses four power supplies, $\pm 5 \mathrm{~V}$ and $\pm 15 \mathrm{~V}$, and an external 10 MHz clock. Power dissipation is nominally 2.8 W . Two user selectable bipolar input ranges, $\pm 5 \mathrm{~V}$ and $\pm 10 \mathrm{~V}$ are provided. Careful attention to grounding and a single package make it easy to design PCBs to achieve specified performance.

SDEGFGMTONS $\left(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=-5 \mathrm{~V}, 10 \mathrm{MHz}\right.$ External Clock, 5 Minute Warm-up, unless otherwise noted)

AD1382

| Parameter | AD1382KD |  |  | Units |
| :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max |  |
| RESOLUTION | 16 |  |  | Bits |
| ANALOG INPUT |  |  |  |  |
| Input Ranges |  | $\pm 5, \pm 10$ |  | V |
| Input Impedance | 2.45 | 2.5 | 2.55 | $\mathrm{k} \Omega$ |
| TRANSFER CHARACTERISTICS |  |  |  |  |
|  |  |  |  |  |  |
| Integral Nonlinearity ${ }^{1}$ |  | $\pm 0.0015$ |  | \% FSR ${ }^{2}$ |
| Differential Nonlinearity ${ }^{1}$ |  | $\pm 0.0006$ | $\pm 0.0015$ | \% FSR |
| Missing Codes |  |  | None |  |
| Gain Error ${ }^{3}$ |  | $\pm 0.07$ | $\pm 0.15$ | \% FSR |
| Bipolar Zero ${ }^{3}$ |  | $\pm 0.03$ | $\pm 0.10$ | \% FSR |
| PSRR |  | $\pm 0.006$ | $\pm 0.10$ | \% FSR/V |
| Noise ${ }^{4}$ |  | 55 |  | $\mu$ V RMS |
| DYNAMIC CHARACTERISTICS |  |  |  |  |
| $\pm 5 \mathrm{~V}$ FSR, $\mathrm{V}_{\text {IN }}=-0.4 \mathrm{~dB}$ |  |  |  |  |
| Sample Rate |  |  | 500 | kHz |
| Signal-to-Noise Ratio ${ }^{5}$ |  |  |  |  |
| $\mathrm{f}=5 \mathrm{kHz}$ | 90 | 93 |  | dB |
| $\mathrm{f}=100 \mathrm{kHz}$ | 90 | 92 |  | dB |
| $\mathrm{f}=200 \mathrm{kHz}$ | 88 | 91 |  | dB |
| Peak Distortion |  |  |  |  |
| $\mathrm{f}=5 \mathrm{kHz}$ | -90 | -98 |  | dB |
| $\mathrm{f}=100 \mathrm{kHz}$ | -88 | -93 |  | dB |
| $\mathrm{f}=200 \mathrm{kHz}$ | -82 | -85 |  | dB |
| Total Harmonic Distortion ${ }^{6}$ |  |  |  |  |
| $\mathrm{f}=5 \mathrm{kHz}$ | -90 | -96 |  | dB |
| $\mathrm{f}=100 \mathrm{kHz}$ | -88 | -92 |  | dB |
| $\mathrm{f}=200 \mathrm{kHz}$ | -82 | -85 |  | dB |
| DYNAMIC CHARACTERISTICS |  |  |  |  |
| $\pm 10 \mathrm{~V}$ FSR, $\mathrm{V}_{\text {IN }}=-0.4 \mathrm{~dB}$ |  |  |  |  |
| Sample Rate |  |  | 500 | kHz |
| Signal-to-Noise Ratio ${ }^{5}$ |  |  |  |  |
| $\mathrm{f}=5 \mathrm{kHz}$ | 90 | 95 |  | dB |
| $\mathrm{f}=100 \mathrm{kHz}$ | 90 | 94 |  | dB |
| $\mathrm{f}=200 \mathrm{kHz}$ | 88 | 93 |  | dB |
| Peak Distortion |  |  |  |  |
| $\mathrm{f}=5 \mathrm{kHz}$ | -90 | -98 |  | dB |
| $\mathrm{f}=100 \mathrm{kHz}$ | -80 | -87 |  | dB |
| $\mathrm{f}=200 \mathrm{kHz}$ | -74 | -81 |  | dB |
| Total Harmonic Distortion ${ }^{6}$ ( ${ }^{\text {a }}$ |  |  |  |  |
| $\mathrm{f}=5 \mathrm{kHz}$ | -90 | -96 |  | dB |
| $\mathrm{f}=100 \mathrm{kHz}$ | -80 | -87 |  | dB |
| $\mathrm{f}=200 \mathrm{kHz}$ | -74 | -81 |  | dB |
| DIGITAL INPUTS ${ }^{9}$ |  |  |  |  |
| Input Voltage |  |  |  |  |
| $\mathrm{V}_{\text {IL }}$ |  |  | 0.8 | V |
| $\mathrm{V}_{\text {IH }}$ | 2.0 |  |  | V |
| Input Current |  |  | $\pm 200$ | $\mu \mathrm{A}$ |
| Input Capacitance |  | 2 |  | pF |
| Start Command. V $^{\text {a }}$ |  |  |  |  |
| Setup Time, $\mathrm{t}_{\text {scs }}$ | 10 | 3 |  | ns |
| Hold Time, $\mathrm{t}_{\mathrm{sch}}$ | 10 | 0 |  | ns |
| Autozero |  |  |  |  |
| Setup Time, $\mathrm{t}_{\text {azs }}$ | 10 | 0 |  | ns |
| Hold Time, $\mathrm{t}_{\text {AzH }}$ | 20 | 6 |  | ns |
| Clock |  |  |  |  |
| Frequency | 2.5 |  | 10 | MHz |
| Duty Cycle | 40 |  | 60 | \% |

$V_{\mathrm{IN}}=-0.4 \mathrm{~dB}$
Signal-to-Noise Ratio ${ }^{5}$
$\mathrm{f}=5 \mathrm{kHz}$
f 100 kHz
Peak Distortion
$\mathrm{f}=5 \mathrm{kHz}$
$\mathrm{f}=100 \mathrm{kHz}$
$\mathrm{f}=200 \mathrm{kHz}$
Total Harmonic Distortion ${ }^{6}$
f
YNAMIC CHARACTERISTICS
$\pm 10$ V FSR, $\mathrm{V}_{\mathrm{IN}}=-0.4 \mathrm{~dB}$
Sample Rate ignal-to-Noise Ratio ${ }^{5}$
$\mathrm{f}=100 \mathrm{kHz}$
$\mathrm{f}=200 \mathrm{kHz}$
ak Distortion
$\mathrm{f}=100 \mathrm{kHz}$
$\mathrm{f}=200 \mathrm{kHz}$
tal Harmonic Distortion

$$
\mathrm{f}=100 \mathrm{kHz}
$$

$\mathrm{f}=200 \mathrm{kHz}$
DIGITAL INPUTS ${ }^{9}$
Input Voltage

Input Current
Input Capacitance Command scs
utozero Setup Time, $\mathrm{t}_{\text {azs }}$ Time, $\mathrm{t}_{\mathrm{AZH}}$ Frequency Duty Cycle

| Parameter | Min | $\begin{gathered} 1382 K \\ \mathbf{T y p} \end{gathered}$ | Max | Units |
| :---: | :---: | :---: | :---: | :---: |
| DIGITAL INPUTS (Continued) Aperture Delay ${ }^{7}$ |  | 7 |  | ns |
| DIGITAL OUTPUTS ${ }^{8,9}$ <br> Output Voltage $\mathrm{V}_{\mathrm{OL}} @ \mathrm{I}_{\mathrm{OL}}=3.2 \mathrm{~mA}$ <br> $\mathrm{V}_{\mathrm{OH}} @ \mathrm{I}_{\mathrm{OH}}=-3.2 \mathrm{~mA}$ <br> Output Capacitance <br> Leakage, Outputs Disabled <br> Data Valid <br> Setup Time, $\mathrm{t}_{\mathrm{Dvs}}$ <br> Hold Time, $\mathrm{t}_{\mathrm{DVH}}$ <br> Hold Command Time, $\mathrm{t}_{\mathbf{H}}$ <br> Hold Command Delay, $\mathrm{t}_{\mathrm{HD}}$ <br> Data Strobe Pulse Width, $\mathrm{t}_{\mathrm{DS}}$ <br> Data Strobe Delay, $t_{\text {DSD }}$ | $2.4$ <br> 75 <br> 25 | 0.2 <br> 4.5 <br> 10 <br> 150 <br> 50 <br> 1300 <br> 6 <br> 200 <br> 1650 | $0.4$ $\pm 200$ | V <br> V <br> pF <br> $\mu \mathrm{A}$ <br> ns <br> ns <br> ns <br> ns <br> ns <br> ns |
| OUTPUT CODING |  | ntary <br> tary T |  |  |
| PERFORMANCE OVER TEMPERATURE ${ }^{8,10}$ <br> Operating Temperature Range <br> Specified Temperature Range <br> Missing Codes <br> Gain Drift <br> Offset Drift <br> Differential Linearity | $\begin{aligned} & 0 \\ & 10 \end{aligned}$ | $\begin{aligned} & 8 \\ & 5 \\ & 0.3 \end{aligned}$ | 70 <br> 40 <br> None <br> 15 <br> 15 | ${ }^{\circ} \mathrm{C}$ ${ }^{\circ} \mathrm{C}$ $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ |
| INTERNAL REFERENCE <br> Voltage <br> Current | $\begin{aligned} & 9.990 \\ & 2 \end{aligned}$ | 10 | 10.010 | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~mA} \end{aligned}$ |
| ```POWER REQUIREMENTS Operating Range \(\pm V_{s}\) \(+V_{D D}\) \(-V_{S s}\) Current Drains \(+V_{s}\) \(-V_{S}\) \(+V_{D D}\) \(-V_{s s}\) Power Dissipation``` | $\begin{aligned} & 14.25 \\ & 4.75 \\ & -5.25 \end{aligned}$ | $\begin{aligned} & 50 \\ & 45 \\ & 115 \\ & 160 \\ & 2.8 \end{aligned}$ | $\begin{aligned} & 15.75 \\ & 5.25 \\ & -4.75 \\ & 73 \\ & 65 \\ & 160 \\ & 200 \\ & 3.9 \end{aligned}$ | V <br> V <br> V <br> mA <br> mA <br> mA <br> mA <br> Watts |

## NOTES

${ }^{1}$ Integral linearity is inferred from FFT. Differential linearity is derived from histogram.
${ }^{2}$ FSR, full-scale range.
${ }^{3}$ Adjustable to zero.
${ }^{4}$ Noise based on small signal FFT excluding quantization noise.
${ }^{\text {s }}$ SNR fundamental to noise minus harmonics 2-9.
${ }^{6}$ THD includes harmonics $2-9$ of the fundamental.
${ }^{7}$ Aperture delay is the time from the rising edge on the Hold Command Input to the opening of the switch in the Track/Hold.
${ }^{8}$ Guaranteed but not $100 \%$ production tested.
${ }^{9}$ Timing based on 10 MHz clock. Refer to Figures 13 and 14.
${ }^{10} \mathrm{Case}$ to ambient temperature is assumed to be $30^{\circ} \mathrm{C}$. The AD1 382 case temperature will stabilize about $30^{\circ} \mathrm{C}$ above ambient while operating in free air without a heat sink. Factory calibration is done in this condition. See the application section for further information.
Specifications subject to change without notice.

ABSOLUTE MAXIMUM RATINGS

+ $\mathrm{V}_{\mathrm{s}}$ to AGND . . . . . . . . . . . . . . . . . . . . . . . . . . . . 18 V
- V to AGND . . . . . . . . . . . . . . . . . . . . . . . . . . . - 18 V
$V_{D D}$ to PGND . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 7 V
V ${ }_{\text {ss }}$ to PGND . . . . . . . . . . . . . . . . . . . . . . . . . . . . -7 V
AGND to PGND . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 0.3$ V
Analog Inputs . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm \mathrm{V}_{\mathrm{S}}$
Digital Inputs . . . . . . . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Output Short Circuit Duration
Reference Output . . . . . . . . . . . . . . . . . . . . . . Indefinite
Track/Hold Output . . . . . . . . . . . . . . . . . . . . . . . . 1 sec
Digital Outputs . . . . . . . . . . . . 1 sec for Any One Output
Ambient Temperature (Operating) . . . . . . . . . $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Storage Temperature . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
*Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.


## AD1382 PIN CONNECTIONS

The AD1382 is housed in a 48 -pin bottom-brazed ceramic bathtub package. The pinout is as follows:

| PIN | FUNCTION | PIN | FUNCTION |
| :---: | :---: | :---: | :---: |
| 1 | CLOCK IN | 48 | $\mathrm{V}_{\text {DD2 } 2}$ (+5 V POWER) |
| 2 | POWER GROUND | 47 | POWER GROUND |
| 3 | B1/B9 MSB | 46 | $\mathrm{V}_{\text {SS2 }}$ (-5 V POWER) |
| 4 | B2/B10 | 45 | AUTOZERO |
| 5 | B3/B11 | 44 | B1 SELECT |
| 6 | B4/B12 | 43 | POWER GROUND |
| 7 | B5/B13 | 42 | POWER GROUND |
| 8 | B6/B14 | 41 | DNC |
| 9 | B7/B15 | 40 | GAIN ADJUST |
| 10 | B8/B16 LSB | 39 | +10 V REFERENCE OUT |
| 11 | $\mathrm{V}_{\mathrm{DD} 1}$ ( +5 V SIGNAL) | 38 | $-\mathrm{V}_{\mathrm{s} 1}(-15 \mathrm{~V})$ |
| 12 | POWER GROUND | 37 | SIGNAL GROUND |
| 13 | $\mathrm{V}_{\text {Ss } 1}$ (-5 V SIGNAL) | 36 | $+\mathrm{V}_{\text {S } 1}$ ( +15 V ) |
| 14 | SIGNAL GROUND | 35 | SIGNAL GROUND |
| 15 | DATA STROBE | 34 | DNC |
| 16 | HI/LO BYTE SELECT | 33 | DNC |
| 17 | OE DATA ENABLE | 32 | +10 V REFERENCE IN |
| 18 | START CONVERT | 31 | $\mathrm{V}_{\text {IN }} \mathrm{B}$ |
| 19 | HOLD COMMAND OUT | 30 | $\mathrm{V}_{\text {IN }} \mathrm{A}$ |
| 20 | SIGNAL GROUND | 29 | OFFSET ADJUST |
| 21 | $+\mathrm{V}_{\text {S2 }}$ ( +15 V ) | 28 | DNC |
| 22 | HOLD COMMAND IN | 27 | TRACK/HOLD OUTPUT |
| 23 | $-\mathrm{V}_{\mathrm{s} 2}$ (-15 V) | 26 | SIGNAL GROUND |
| 24 | POWER GROUND | 25 | TRACK/HOLD INPUT |

DNC = DO NOT CONNECT

## CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are removed.

ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Option |
| :--- | :--- | ---: |
| AD1382KD | $10^{\circ} \mathrm{C}$ to $40^{\circ} \mathrm{C}$ Ambient <br> $\left(40^{\circ} \mathrm{C}\right.$ to $70^{\circ} \mathrm{C}$ Case $)$ | DH-48A |

*DH-48A = Hermetic Ceramic DIP. For outline information see Package Information section.

PRODUCT FEATURES<br>16-Bit Resolution<br>500 kHz Sampling Rate<br>Differential Linearity Autocalibration<br>Specified over $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ Range<br>SNR 90 dB @ 100 kHz (min)<br>THD - 88 dB @ 100 kHz ( min )<br>0.0006\% FSR DNL (typ)<br>0.0015\% FSR INL (typ)<br>No Missing Codes<br>$\pm 5, \pm 10$ V Bipolar Input Ranges<br>Zero Offset Autocalibration<br>APPLICATIONS<br>Medical Imaging CAT<br>Magnetic Resonance<br>Radar<br>Vibration Analysis<br>Parametric Measurement Unit (ATE)<br>Digital Storage Oscilloscopes<br>Waveform Recorders<br>Analytical Instruments

## PRODUCT DESCRIPTION

The AD1385 is a complete $500 \mathrm{kHz}, 16$-bit, sampling analog-todigital converter contained in a single package. Its differential linearity autocalibration feature allows this high resolution, high speed converter to offer outstanding noise and distortion performance, as well as excellent INL and DNL specifications, over the full military temperature range. Autocalibration effectively eliminates DNL drift over temperature.
The AD1385 architecture includes a low noise, low distortion track/hold, a three pass digitally corrected subranging ADC, and linearity calibration circuitry. A complete linearity calibration requires only 15 ms . Precision thin-film resistors and a proprietary DAC contribute to the part's outstanding dynamic and static performance.

FUNCTIONAL BLOCK DIAGRAM


The AD1385 uses four power supplies, $\pm 5 \mathrm{~V}$ and $\pm 15 \mathrm{~V}$, and an external 10 MHz clock. Power dissipation is nominally 2.76 W . Two user selectable bipolar input ranges, $\pm 5 \mathrm{~V}$ and $\pm 10 \mathrm{~V}$, are provided. Careful attention to grounding and a single package make it easy to design PCBs to achieve specified performance.
The AD1385's pinout is nearly identical to that of the AD1382, a factory calibrated 16 -bit, 500 kHz SADC. Just two additional connections, to enable and monitor autocalibration, are required. This commonality provides an easy upgrade path to extend system performance and operating temperature range.

[^69]SDESFRATMNE $\left(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=-5 \mathrm{~V}, 10 \mathrm{MHz}\right.$ External Clock,
unless otherwise noted)
AD1385

| Parameter | AD1385KD |  |  | AD1385TD |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max |  |
| RESOLUTION | 16 |  |  | 16 |  |  | Bits |
| ANALOG INPUT |  |  |  |  |  |  |  |
| Input Ranges |  | $\pm 5, \pm 10$ |  |  | $\pm 5, \pm 10$ |  | V |
| Input Impedance | 2.45 | 2.5 | 2.55 | 2.45 | 2.5 | 2.55 | k $\Omega$ |
| TRANSFER CHARACTERISTICS |  |  |  |  |  |  |  |
| (Combined ADC/Track/Hold) |  |  |  |  |  |  |  |
| Integral Nonlinearity ${ }^{1,2}$, $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |  | $\pm 0.0015$ |  |  | $\pm 0.0015$ |  | \% FSR ${ }^{3}$ |
| Differential Nonlinearity ${ }^{1}$ MIN ${ }^{\text {a }}$ ( ${ }^{\text {a }}$ |  | $\pm 0.0006$ | $\pm 0.0015$ |  | $\pm 0.0006$ | $\pm 0.0015$ | \% FSR |
| Drift, $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |  | 0.3 |  |  | 0.3 |  | ppm/ ${ }^{\circ} \mathrm{C}$ |
| Missing Codes, $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |  |  | None |  |  | None |  |
| Gain Error ${ }^{4}$ |  | $\pm 0.05$ | $\pm 0.15$ |  | $\pm 0.05$ | $\pm 0.15$ | \% FSR |
| Drift, $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {max }}$ |  | 8 |  |  |  | 15 | ppm/ ${ }^{\circ} \mathrm{C}$ |
| Bipolar Zero ${ }^{4}$ |  | $\pm 0.05$ | $\pm 0.10$ |  | $\pm 0.05$ | $\pm 0.10$ | \% FSR |
| Drift, $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |  | 5 |  |  | 5 |  | ppm/ $/{ }^{\circ} \mathrm{C}$ |
| PSRR MIN |  | $\pm 0.006$ | $\pm 0.10$ |  | $\pm 0.006$ | $\pm 0.10$ | \% FSR/V |
| Noise |  | 70 |  |  | 70 |  | $\mu$ V RMS |
|  |  |  |  |  |  |  |  |
| $\pm 5 \mathrm{~V}$ FSR, $\mathrm{V}_{\text {IN }}=-0.4 \mathrm{~dB}, \mathrm{~T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |  |  |  |  |  |  |  |
| Sample Rate |  |  | 500 |  |  | 500 | kHz |
| Signal-to-Noise Ratio ${ }^{5}$ |  |  |  |  |  |  |  |
| $\mathrm{f}=5 \mathrm{kHz}$ | 90 | 93 |  | 90 | 93 |  | dB |
| $\mathrm{f}=100 \mathrm{kHz}$ | 90 | 92 |  | 90 | 92 |  | dB |
| $\mathrm{f}=200 \mathrm{kHz}$ | 88 | 91 |  | 88 | 91 |  | dB |
| Peak Distortion |  |  |  |  |  |  |  |
| $\mathrm{f}=5 \mathrm{kHz}$ | -90 | -107 |  | -90 | -107 |  | dB |
| $\mathrm{f}=100 \mathrm{kHz}$ | -88 | -95 |  | -88 | -95 |  | dB |
| $\mathrm{f}=200 \mathrm{kHz}$ | -82 | -88 |  | -82 | -88 |  | dB |
| Total Harmonic Distortion ${ }^{6}$ |  |  |  |  |  |  |  |
| $\mathrm{f}=5 \mathrm{kHz}$ | -90 | -105 |  | -90 | -105 |  | dB |
| $\mathrm{f}=100 \mathrm{kHz}$ | -88 | -95 |  | -88 | -95 |  | dB |
| $\mathrm{f}=200 \mathrm{kHz}$ | -82 | -88 |  | -82 | -88 |  | dB |
| DYNAMIC CHARACTERISTICS ${ }^{2}$ |  |  |  |  |  |  |  |
| $\pm 10 \mathrm{~V} \text { FSR, } \mathrm{V}_{\text {IN }}=-0.4 \mathrm{~dB}, \mathrm{~T}_{\text {MIN }} \text { to } \mathrm{T}_{\mathrm{MAX}}$ |  |  | 500 |  |  | 500 | kHz |
| Signal-to-Noise Ratio ${ }^{5}$ - S $^{\text {S }}$ |  |  |  |  |  |  |  |
| $\mathrm{f}=5 \mathrm{kHz}$ | 90 | 95 |  | 90 | 95 |  | dB |
| $\mathrm{f}=100 \mathrm{kHz}$ | 90 | 94 |  | 90 | 94 |  | dB |
| $\mathrm{f}=200 \mathrm{kHz}$ | 88 | 93 |  | 88 | 93 |  | dB |
| Peak Distortion |  |  |  |  |  |  |  |
| $\mathrm{f}=5 \mathrm{kHz}$ | -90 | -108 |  | -90 | -108 |  | dB |
| $\mathrm{f}=100 \mathrm{kHz}$ | -80 | -87 |  | -80 | -87 |  | dB |
| $\mathrm{f}=200 \mathrm{kHz}$ | -74 | -82 |  | -74 | -82 |  | dB |
| Total Harmonic Distortion ${ }^{6}$ |  |  |  |  |  |  |  |
| $\mathrm{f}=5 \mathrm{kHz}$ | -90 | -105 |  | -90 | -105 |  | dB |
| $\mathrm{f}=100 \mathrm{kHz}$ | -80 | -87 |  | -80 | -87 |  | dB |
| $\mathrm{f}=200 \mathrm{kHz}$ | -74 | -82 |  | -74 | -82 |  | dB |
| DIGITAL INPUTS |  |  |  |  |  |  |  |
| Input Voltage |  |  |  |  |  |  |  |
| $\mathrm{V}_{\text {IL }}$ |  |  | 0.8 |  |  | 0.8 | V |
| $\mathrm{V}_{\mathrm{IH}}$ | 2.25 |  |  | 2.25 |  |  | V |
| Input Current |  |  | $\pm 200$ |  |  | $\pm 200$ | $\mu \mathrm{A}$ |
| Input Capacitance |  | 2 |  |  | 2 |  | pF |
| Clock |  |  |  |  |  |  |  |
| Frequency |  | 2.5-10 |  |  | $2.5-10$ |  | $\mathrm{MHz}$ |
| Duty Cycle |  | 40-60 |  |  | 40-60 |  | \% |
| Aperture Delay ${ }^{7}$ |  | 7 |  |  | 7 |  | ns |
| DIGITAL OUTPUTS |  |  |  |  |  |  |  |
| Output Voltage |  |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{OL}} @ \mathrm{I}_{\mathrm{OL}}=3.2 \mathrm{~mA}$ |  | 0.2 | 0.4 |  |  | 0.4 |  |
| $\mathrm{V}_{\mathrm{OH}} @ \mathrm{I}_{\mathrm{OH}}=-3.2 \mathrm{~mA}$ | 2.4 | 4.5 |  | 2.4 | 4.5 |  | V |
| Output Capacitance |  | 4 |  |  | 4 |  | pF |
| Leakage, Outputs Disabled |  |  | $\pm 200$ |  |  | $\pm 200$ | $\mu \mathrm{A}$ |


| Parameter | Min | $\begin{gathered} 1385 \mathrm{~K} \\ \text { Typ } \end{gathered}$ | Max | Min | $\begin{gathered} 13851 \\ \text { Typ } \end{gathered}$ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| OUTPUT CODING | Complementary Offset Binary or Complementary Twos Complement |  |  |  |  |  |  |
| INTERNAL REFERENCE <br> Voltage <br> Current <br> Drift | $\begin{aligned} & 9.990 \\ & 2 \end{aligned}$ | $\begin{aligned} & 5 \\ & 5 \end{aligned}$ | $10.010$ $15$ | $\begin{aligned} & 9.990 \\ & 2 \end{aligned}$ | $5$ | $\begin{aligned} & 10.010 \\ & 15 \end{aligned}$ | V mA $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ |
| TEMPERATURE RANGE, CASE <br> Specified <br> Storage | $\begin{aligned} & 0 \\ & -65 \end{aligned}$ |  | $\begin{aligned} & +70 \\ & +150 \end{aligned}$ | $\begin{aligned} & -55 \\ & -65 \end{aligned}$ |  | $\begin{aligned} & +125 \\ & +150 \\ & \hline \end{aligned}$ | $\begin{aligned} & { }^{\circ} \mathrm{C} \\ & { }^{\circ} \mathrm{C} \end{aligned}$ |
| POWER REQUIREMENTS Specified Operating Range $\pm V_{\text {s }}$ $+V_{D D}$ $-\mathrm{V}_{\mathrm{ss}}$ <br> Current Drains <br> $+V_{S}$ <br> $-V_{S}$ $+V_{D D}$ $-\mathrm{V}_{\mathrm{ss}}$ <br> Power Dissipation | $\begin{aligned} & 14.25 \\ & 4.75 \\ & -5.25 \end{aligned}$ | $\begin{aligned} & 52 \\ & 48 \\ & 104 \\ & 148 \\ & 2.76 \end{aligned}$ | $\begin{aligned} & 15.75 \\ & 5.25 \\ & -4.75 \\ & 80 \\ & 75 \\ & 160 \\ & 200 \\ & 4.125 \end{aligned}$ | $\begin{aligned} & 14.25 \\ & 4.75 \\ & -5.25 \end{aligned}$ | $\begin{aligned} & 52 \\ & 48 \\ & 104 \\ & 148 \\ & 2.76 \end{aligned}$ | $\begin{aligned} & 15.75 \\ & 5.25 \\ & -4.75 \\ & 80 \\ & 75 \\ & 160 \\ & 200 \\ & 4.125 \end{aligned}$ | V <br> V <br> V <br> mA <br> mA <br> mA <br> mA <br> Watts |

NOTES
${ }^{1}$ Integral linearity is inferred from FFTs. Differential linearity is derived from histograms.
${ }^{2}$ Performance over temperature is specified at the temperature at which the last calibration was performed.
${ }^{3}$ FSR $=$ Full-Scale Range.
${ }^{4}$ Adjustable to zero.
${ }^{5}$ SNR excludes harmonics 2-9 of the fundamental.
${ }^{6}$ THD includes harmonics 2-9 of the fundamental.
${ }^{7}$ Aperture delay is the time from the rising edge on the Hold Command Input to the opening of the switch in the Track/Hold.
Specifications subject to change without notice.
TIMING SPECIFICATIONS ${ }^{1,2}$
$\left(\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}\right.$ to $\left.+125^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=-5 \mathrm{~V}\right)$

| Parameter | Design Minimum | Typ | Unit | Description |
| :---: | :---: | :---: | :---: | :---: |
| START COMMAND <br> $\mathrm{t}_{\mathrm{sCS}}$ <br> $\mathrm{t}_{\mathrm{SCH}}$ | $\begin{aligned} & 10 \\ & 10 \end{aligned}$ |  | $\begin{aligned} & \text { ns } \\ & \text { ns } \end{aligned}$ | Setup Time <br> Hold Time |
| $\begin{gathered} \hline \text { AUTOZERO } \\ t_{\mathrm{AZs}} \\ \mathrm{t}_{\mathrm{AZH}} \\ \hline \end{gathered}$ | $\begin{aligned} & 10 \\ & 20 \end{aligned}$ |  | $\begin{aligned} & \text { ns } \\ & \text { ns } \end{aligned}$ | Setup Time Hold Time |
| DATA VALID $\mathrm{t}_{\mathrm{Dvs}}$ $\mathrm{t}_{\mathrm{DVH}}$ |  | $\begin{aligned} & 1.5 \\ & 0.5 \end{aligned}$ | $\begin{aligned} & \mathrm{CP}^{3} \\ & \mathrm{CP}^{3} \end{aligned}$ | Setup Time Hold Time |
| $\begin{aligned} & \text { HOLD COMMAND } \\ & \mathrm{t}_{\mathrm{H}} \\ & \mathrm{t}_{\mathrm{D}} \end{aligned}$ |  | $\begin{aligned} & 13 \\ & 7 \end{aligned}$ | $\begin{aligned} & \mathrm{CP}^{3} \\ & \mathrm{~ns} \end{aligned}$ | Hold Time Delay Time |
| DATA STROBE $t_{\mathrm{DS}}$ $t_{\text {DSD }}$ |  | $\begin{aligned} & 2 \\ & 16.5 \end{aligned}$ | $\begin{aligned} & \mathrm{CP}^{3} \\ & \mathrm{CP}^{3} \end{aligned}$ | Pulse Width Delay |
| CALIBRATE PULSE WIDTH | 20 |  | ns |  |
| CALIBRATION STATUS |  | 15 | ms | Duration |

NOTE
${ }^{1}$ Refer to Figures 17, 18 and 24.
${ }^{2}$ Design minimums are derived from worst case design analysis and/or simulation results. Typical values are based on characterization data. These specifications are not guaranteed or tested.
${ }^{3}$ The time duration for this parameter varies in direct proportion to the width of the Clock Pulse (CP).

## ABSOLUTE MAXIMUM RATINGS* ${ }^{\star}$

+ $\mathrm{V}_{\mathrm{S}}$ to AGND . . . . . . . . . . . . . . . . . . . . . . . . . . 18 V
$\mathrm{V}_{\mathrm{s}}$ to AGND
V $_{\text {DD }}$ to PGND . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 7 V
Vss to PGND . . . . . . . . . . . . . . . . . . . . . . . . . . . . -7 V
AGND to PGND . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 0.3$ V
Analog Inputs . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm \mathrm{V}_{\text {S }}$
Reference Input . . . . . . . . . . . . . . . . . . . . . 0 V to +11 V
Digital Inputs . . . . . . . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Output Short Circuit Duration
Reference Output . . . . . . . . . . . . . . . . . . . . . . Indefinite
Track/Hold Output . . . . . . . . . . . . . . . . . . . . . . . . 1 sec
Digital Outputs . . . . . . . . . . . 1 sec for Any One Output
Case Temperature (Operating) . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
*Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ORDERING GUIDE

| Model | Temperature <br> Range (Case) | Package Option |
| :--- | :--- | :--- |

*DH-48A = Bottom Brazed Ceramic DIP. For outline information see Package Information section.

## AD1385 PIN CONNECTIONS

The AD1385 is housed in a 48 -pin bottom-brazed ceramic bathtub package. The pinout is as follows:

| Pin | Function | Pin | Function |
| :---: | :---: | :---: | :---: |
| 1 | CLOCK IN | 48 | $\mathrm{V}_{\text {DD2 }}$ (+5 V POWER) |
| 2 | POWER GROUND | 47 | POWER GROUND |
| 3 | B1/B9 (MSB) | 46 | $\mathrm{V}_{\text {SS2 }}$ (-5 V POWER) |
| 4 | B2/B10 | 45 | AUTOZERO |
| 5 | B3/B11 | 44 | B1 SELECT |
| 6 | B4/B12 | 43 | POWER GROUND |
| 7 | B5/B13 | 42 | POWER GROUND |
| 8 | B6/B14 | 41 | $\overline{\text { CAL }}$ |
| 9 | B7/B15 | 40 | GAIN ADJUST |
| 10 | B8/B16 (LSB) | 39 | + 10 V REFERENCE OUT |
| 11 | $\mathrm{V}_{\text {DD1 }}(+5 \mathrm{~V}$ SIGNAL) | 38 | $-\mathrm{V}_{\text {S }}(-15 \mathrm{~V})$ |
| 12 | POWER GROUND | 37 | SIGNAL GROUND |
| 13 | $\mathrm{V}_{\text {SSI }}$ ( -5 V SIGNAL) | 36 | $+\mathrm{V}_{\text {S }}(+15 \mathrm{~V})$ |
| 14 | SIGNAL GROUND | 35 | SIGNAL GROUND |
| 15 | DATA STROBE | 34 | DNC |
| 16 | HI/LO BYTE SELECT | 33 | DNC |
| 17 | $\overline{O E}$ DATA ENABLE | 32 | + 10 V REFERENCE IN |
| 18 | START CONVERT | 31 | $\mathrm{V}_{\text {IN }} \mathrm{B}$ |
| 19 | HOLD COMMAND OUT | 30 | $\mathrm{V}_{\text {IN }} \mathrm{A}$ |
| 20 | SIGNAL GROUND | 29 | OFFSET ADJUST |
| 21 | $+\mathrm{V}_{\mathrm{S} 2}(+15 \mathrm{~V})$ | 28 | CAL STATUS |
| 22 | HOLD COMMAND IN | 27 | TRACK/HOLD OUTPUT |
| 23 | $-\mathrm{V}_{\mathrm{S} 2}(-15 \mathrm{~V})$ | 26 | SIGNAL GROUND |
| 24 | POWER GROUND | 25 | TRACK/HOLD INPUT |

DNC $=$ DO NOT CONNECT

## CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are removed.
 3 V/5 V, Low Cost, Low Power, 16-Bit, Sigma-Delta ADC

FEATURES
Charge-Balancing ADC
16 Bits No Missing Codes
0.0015\% Nonlinearity

Programmable Gain Front End
Gains of 1, 2, 32 and 128
Differential Input Capability
Three-Wire Serial Interface Ability to Buffer the Analog Input 3 V or 5 V Single Supply Operation
Low Supply Current: $500 \mu$ A max @ 3 V Supplies Low-Pass Filter with Programmable Output Update 16-Pin SOIC/DIP

## GENERAL DESCRIPTION

The AD7715 is a complete analog front end for low frequency measurement applications. The part can accept low level input signals directly from a transducer and outputs a serial digital word. It employs a sigma-delta conversion technique to realize up to 16 bits of no missing codes performance. The input signal is applied to a proprietary programmable gain front end based around an analog modulator. The modulator output is processed by an on-chip digital filter. The first notch of this digital filter can be programmed via the on-chip control register allowing adjustment of the filter cutoff and output update rate.
The AD7715 features a differential analog input as well as a differential reference input. It operates from a single supply ( +3 V or +5 V ). It can handle unipolar input signal ranges of 0 mV to $+20 \mathrm{mV}, 0 \mathrm{mV}$ to $+80 \mathrm{mV}, 0 \mathrm{~V}$ to +1.25 V and 0 V to +2.5 V . It can also handle bipolar input signal ranges of $\pm 20 \mathrm{mV}$, $\pm 80 \mathrm{mV}, \pm 1.25 \mathrm{~V}$ and $\pm 2.5 \mathrm{~V}$. These bipolar ranges are referenced to the negative input of the differential analog input. The AD7715 thus performs all signal conditioning and conversion for a single-channel system.
The AD7715 is ideal for use in smart, microcontroller or DSP based systems. It features a serial interface which can be configured for three-wire operation. Gain settings, signal polarity and update rate selection can be configured in software using the input serial port. The part contains self-calibration and system calibration options to eliminate gain and offset errors on the part itself or in the system.
CMOS construction ensures very low power dissipation and the power-down mode reduces the standby power consumption to $50 \mu \mathrm{~W}$ typ. The part is available in a 16 -pin, 0.3 inch-wide, plastic and hermetic dual-in-line package (DIP) as well as a 16lead small outline (SOIC) package.
*Protected by U.S. Patent No. $\mathbf{5 , 1 3 4 , 4 0 1}$.
This is a preliminary data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

FUNCTIONAL BLOCK DIAGRAM


PRODUCT HIGHLIGHTS

1. The AD 7715 consumes less than $500 \mu \mathrm{~A}$ in total supply current at 3 V supplies and 1 MHz master clock, making it ideal for use in low-power systems. Standby current is less than $10 \mu \mathrm{~A}$
2. The programmable gain input allows the AD 7715 to accept input signals directly from a strain gage or transducer removing a considerable amount of signal conditioning.
3. The AD7715 is ideal for microcontroller or DSP processor applications with a three-wire serial interface reducing the number of interconnect lines and reducing the number of opto-couplers required in isolated systems. The part contains an on-chip registers which allow software control over output update rate, input gain, signal polarity and calibration modes.
4. The part features excellent static performance specifications with 16 -bit No Missing Codes, $\pm 0.0015 \%$ accuracy and low rms noise ( $<450 \mathrm{nV}$ ). Endpoint errors and the effects of temperature drift are eliminated by on-chip self-calibration, which removes zero-scale and full-scale errors.

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$$
\left(\mathrm{AV}_{D 0}=+5 \mathrm{~V}, \mathrm{DV} \mathrm{DOD}_{\mathrm{DO}}=+3 \mathrm{~V} \text { or }+5 \mathrm{~V}\right. \text {, REF IN(+) =+2.5 V; REF IN(-) = AGND; }
$$

$\mathrm{f}_{\text {CLKII }}=2.4576 \mathrm{MHz}$ unless otherwise noted. All specifications $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {max }}$ unless otherwise noted.)


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AD7715-3-SPECIFICATIONS
$\left(A V_{D D}=+3 \mathrm{~V}, \mathrm{DV}_{D D}=+3 \mathrm{~V}, \operatorname{REF} \operatorname{IN}(+)=+1.25 \mathrm{~V} ; \operatorname{REF} \operatorname{IN}(-)=\mathrm{AGND} ;\right.$
$\mathrm{f}_{\text {clixiw }}=2.4576 \mathrm{MHz}$ unless otherwise noted. All specifications $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {max }}$ unless otherwise noted.)


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| Parameter | A Version | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: |
| SYSTEM CALIBRATION <br> Positive Full-Scale Calibration Limit ${ }^{15}$ Negative Full-Scale Calibration Limit ${ }^{15}$ Offset Calibration Limit ${ }^{16}$ Input Span ${ }^{16}$ | $\begin{aligned} & \left(1.05 \times \mathrm{V}_{\text {REF }} /\right. \text { /GAIN } \\ & -\left(1.05 \times \mathrm{V}_{\mathrm{REF}}\right) / \mathrm{GAIN} \\ & -\left(1.05 \times \mathrm{V}_{\mathrm{REF}}\right) / \mathrm{GAIN} \\ & 0.8 \times \mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN} \\ & \left(2.1 \times \mathrm{V}_{\mathrm{REF}}\right) / \mathrm{GAIN} \end{aligned}$ | V max <br> V max <br> V max <br> V min <br> V max | GAIN Is the Selected PGA Gain (Between 1, 2, 32 or 128) GAIN Is the Selected PGA Gain (Between 1, 2, 32 or 128) GAIN Is the Selected PGA Gain (Between 1, 2, 32 or 128) GAIN Is the Selected PGA Gain (Between 1, 2, 32 or 128) GAIN Is the Selected PGA Gain (Between 1, 2, 32 or 128) |
| POWER REQUIREMENTS <br> Power Supply Voltages <br> $\mathrm{AV}_{\mathrm{DD}}$ Voltage (AD7715-3) <br> $\mathrm{AV}_{\mathrm{DD}}$ Voltage (AD7715-5) <br> DV ${ }_{\text {DD }}$ Voltage <br> Power Supply Currents AV ${ }_{\text {DD }}$ Current <br> $\mathrm{DV}_{\mathrm{DD}}$ Current <br> Power Supply Rejection ${ }^{18}\left(\mathrm{AV}_{\mathrm{DD}}\right)$ Normal Mode Power Dissipation <br> Normal Mode Power Dissipation <br> Standby (Power-Down) Dissipation | $\begin{aligned} & +2.7 \text { to }+3.6 \\ & +5 \\ & +2.7 \text { to }+5.25 \end{aligned}$ <br> 0.3 <br> 0.6 <br> 0.5 <br> 1 <br> 0.2 <br> 0.4 <br> 0.5 <br> 1 <br> See Note 19 <br> 1.5 <br> 2.4 <br> 3 <br> 4.5 <br> 3.5 <br> 5 <br> 7.5 <br> 10 <br> 100 | V nom <br> V nom <br> V nom <br> mA max <br> $m A \max$ <br> $m A$ max <br> $m A \max$ <br> mA max <br> mA max <br> mA max <br> mA max <br> dB typ <br> mW max <br> mW max <br> mW max <br> mW max <br> mW max <br> mW max <br> mW max <br> mW max <br> $\mu \mathrm{W}$ max | For Specified Performance <br> $\pm 5 \%$ for Specified Performance <br> For Specified Performance. $\mathrm{AV}_{\mathrm{DD}}$ must be $\geq \mathrm{DV}_{\mathrm{DD}}$ <br> $A V_{D D}=3 \mathrm{~V}$ or 5 V . Gain $=1$ to $128\left(\mathrm{f}_{\text {CLKIN }}=1 \mathrm{MHz}\right)$ or Gain $=1$ or $2\left(\mathrm{f}_{\text {CLKIN }}=2.4576 \mathrm{MHz}\right.$ ) <br> Typically 0.2 mA . BUF Bit of Setup Register $=0$ <br> Typically 0.4 mA . BUF Bit of Setup Register $=1$ <br> $\mathrm{AV}_{\mathrm{DD}}=3 \mathrm{~V}$ or 5 V . Gain $=32$ or $128\left(\mathrm{f}_{\mathrm{CLKIN}}=2.4576 \mathrm{MHz}\right)^{17}$ <br> Typically 0.3 mA . BUF Bit of Setup Register $=0$ <br> Typically 0.8 mA . BUF Bit of Setup Register $=1$ <br> Digital $L / P s=0 V$ or $D V_{D D}$ <br> Typically $0.15 \mathrm{~mA} . \mathrm{DV}_{\mathrm{DD}}=3 \mathrm{~V} . \mathrm{f}_{\mathrm{CLK} \text { IN }}=1 \mathrm{MHz}$ <br> Typically $0.3 \mathrm{~mA} \mathrm{DV}_{\mathrm{DD}}=5 \mathrm{~V} . \mathrm{f}_{\mathrm{CLK} \text { IN }}=1 \mathrm{MHz}$ <br> Typically $0.4 \mathrm{~mA} \cdot \mathrm{DV}_{\mathrm{DD}}=3 \mathrm{~V} . \mathrm{f}_{\text {CLK IN }}=2.4576 \mathrm{MHz}$ <br> Typically $0.8 \mathrm{~mA} . \mathrm{DV}_{\mathrm{DD}}=5 \mathrm{~V} . \mathrm{f}_{\mathrm{CLK} \text { IN }}=2.4576 \mathrm{MHz}$ <br> $A V_{D D}=D V_{D D}=+3 \mathrm{~V}$. Digital I/Ps $=0 \mathrm{~V}$ or $D V_{D D}$ <br> BUF Bit $=0$. All Gains 1 MHz Clock, Gain 1 and $2 @ 2.4576 \mathrm{MHz}$ <br> BUF Bit $=1$. All Gains 1 MHz Clock, Gain 1 and $2 @ 2.4576 \mathrm{MHz}$ <br> BUF Bit=0. Gain $=32$ or $128 @ \mathrm{f}_{\text {CLKIN }}=2.4576 \mathrm{MHz}$ <br> BUF Bit $=1$. Gain $=32$ or $128 @ \mathrm{f}_{\text {CLKIN }}=2.4576 \mathrm{MHz}$ <br> $\mathrm{AV}_{\mathrm{DD}}=\mathrm{DV} \mathrm{DD}=+5 \mathrm{~V}$. Digital I/Ps $=0 \mathrm{~V}$ or DV DD <br> BUF Bit $=0$. All Gains 1 MHz Clock, Gain 1 and $2 @ 2.4576 \mathrm{MHz}$ <br> BUF Bit $=1$. All Gains 1 MHz Clock, Gain 1 and $2 @ 2.4576 \mathrm{MHz}$ <br> BUF Bit $=0$. Gain $=32$ or $128 @ \mathrm{f}_{\text {CLKIN }}=2.4576 \mathrm{MHz}$ <br> BUF Bit $=1$. Gain $=32$ or $128 @ \mathrm{f}_{\text {CLKIN }}=2.4576 \mathrm{MHz}$ <br> Typically $50 \mu \mathrm{~W}$. STBY Bit of Setup Register $=1$ |

## NOTES

${ }^{1}$ Temperature ranges are as follows: A Version, $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.
${ }^{2}$ Applies after calibration at the temperature of interest.
${ }^{3}$ These errors will be of the order of the output noise of the part as shown in Tables III to VI.
${ }^{4}$ Recalibration at any temperature will remove these drift errors.
${ }^{5}$ Positive Full-Scale Error includes Zero-Scale Errors (Unipolar Offset Error or Bipolar Zero Error) and applies to both unipolar and bipolar input ranges.
${ }^{6}$ Full-Scale Drift includes Zero-Scale Drift (Unipolar Offset Drift or Bipolar Zero Drift) and applies to both unipolar and bipolar input ranges.
${ }^{7}$ Gain Error does not include Zero-Scale Errors. It is calculated as Full-Scale Error-Unipolar Offset Error for unipolar ranges and Full Scale Error-Bipolar Zero Error for bipolar ranges.
${ }^{8}$ Gain Drift does not include Unipolar Offset Drift/Bipolar Zero Drift. It is effectively the drift of the part if zero scale calibrations only were performed.
${ }^{9}$ This common-mode voltage range is allowed provided that the input voltage on AIN $(+)$ or AIN $(-)$ does not go more positive than $A V_{D D}+30$ mV or go more negative than AGND -30 mV .
${ }^{10}$ These numbers are guaranteed by design and/or characterization.
${ }^{11}$ The analog inputs present a very high impedance dynamic load which varies with clock frequency and input sample rate. The maximum recommended source resistance depends on the selected gain.
 positive than $\mathrm{AV}_{\mathrm{DD}}+30 \mathrm{mV}$ or go more negative than $\mathrm{AGND}-30 \mathrm{mV}$.
${ }^{13} \mathrm{~V}_{\mathrm{REF}}=\operatorname{REFIN}(+)-\operatorname{REFIN}(-)$.
${ }^{14}$ Sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance.
${ }^{15}$ After calibration, if the analog input exceeds positive full scale, the converter will output all 1 s . If the analog input is less than negative full scale then the device will output all 0 s .
 set calibration limit applies to both the unipolar zero point and the bipolar zero point.
${ }^{17}$ Assumes CLK bit of Setup Register is set to correct status corresponding to the master clock frequency.
 notches of $6,10,30$ or 60 Hz .
${ }^{19}$ PSRR depends on gain: Gain of $1: 70 \mathrm{~dB}$ typ; Gain of $2: 75 \mathrm{~dB}$ typ; Gains of 32 and $128: 85 \mathrm{~dB}$ typ.
Specifications subject to change without notice.
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| Parameter | Limit at $\mathrm{T}_{\text {MIN }}, \mathrm{T}_{\text {MAX }}$ (A Version) | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: |
| $\mathrm{f}_{\text {CLKIN }}{ }^{3,4}$ | $\begin{aligned} & 400 \\ & 2.5 \end{aligned}$ | kHz min MHz max | Master Clock Frequency: Crystal Oscillator or Externally Supplied for Specified Performance |
| $t_{\text {cle In Lo }}$ | $0.4 \times \mathrm{t}_{\text {CLK }}$ IN | ns min | Master Clock Input Low Time. $\mathrm{t}_{\text {CLK IN }}=1 / \mathrm{f}_{\text {CLK IN }}$ |
| $\mathrm{t}_{\text {CLK IN HI }}$ | $0.4 \times \mathrm{t}_{\text {CLK }} \mathrm{IN}$ | ns min | Master Clock Input High Time |
| $\mathrm{t}_{5}^{5}$ | 50 | ns max | Digital Output Rise Time. Typically 20 ns |
| $t_{f}^{5}$ | $50$ | ns max | Digital Output Fall Time. Typically 20 ns |
| $\mathrm{t}_{1}$ | $500 \times \mathrm{t}_{\text {CLK IN }}$ | ns nom | $\overline{\text { DRDY }}$ High Time |
| $\mathrm{t}_{2}$ | 1000 | ns min | RESET Pulse Width |
| Read Operation |  |  |  |
| $\mathrm{t}_{3}$ | 0 | ns min | $\overline{\mathrm{DRDY}}$ to $\overline{\mathrm{CS}}$ Setup Time |
| ${ }_{\mathrm{t}_{4}}{ }_{6}$ | 20 | $\mathrm{ns} \min$ | $\overline{\text { CS }}$ Falling Edge to SCLK Falling Edge Setup Time |
| $\mathrm{t}_{5}{ }^{6}$ | 0 | ns min | SCLK Falling Edge to Data Valid Delay |
|  | 20 | ns max | $\mathrm{DV}_{\text {DD }}=+5 \mathrm{~V}$ |
|  | 40 | ns max | DV $\mathrm{DD}=+3 \mathrm{~V}$ |
| $\mathrm{t}_{6}$ | 200 | ns min | SCLK High Pulse Width |
| $\mathrm{t}_{7}$ | 200 | ns min | SCLK Low Pulse Width |
|  | 20 | ns min | $\overline{\mathrm{CS}}$ Rising Edge to SCLK Rising Edge Hold Time |
| $\mathrm{t}_{9}{ }^{7}$ | 10 | $\mathrm{ns} \min$ | Bus Relinquish Time after SCLK Rising Edge. |
|  | 50 | ns max | $D V_{D D}=+5 \mathrm{~V}$ |
|  | 100 | ns max | $\mathrm{DV}_{\mathrm{DD}}=+3 \mathrm{~V}$ |
| $\mathrm{t}_{10}$ | 50 | ns max | SCLK Rising Edge to DRDY High ${ }^{8}$ |
| Write Operation |  |  | - ${ }^{\text {CS }}$, |
| $\mathrm{t}_{11}$ | 20 | ns min | CS Falling Edge to SCLK Falling Edge Setup Time |
| $\mathrm{t}_{12}$ | 30 | ns min | Data Valid to SCLK Falling Edge Setup Time |
| $\mathrm{t}_{13}$ | 20 | ns min | - Data Valid to SCLK Falling Edge Hold Time |
| $\mathrm{t}_{14}$ | 200 | ns min | SCLK High Pulse Width |
| $\mathrm{t}_{15}$ | 200 | ns min | SCLK Low Pulse Width |
| $\mathrm{t}_{16}$ | 20 | ns min | $\overline{\text { CS }}$ Rising Edge to SCLK Rising Edge Hold Time |

NOTES
${ }^{1}$ Sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance. All input signals are specified with $\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of DV DD) and timed from a voltage level of 1.6 V .
${ }^{2}$ See Figures 2 and 3.
${ }^{3}$ CLKIN Duty Cycle range is $45 \%$ to $55 \%$. CLKIN must be supplied whenever the AD7715 is not in Standby mode. If no clock is present in this case, the device can draw higher current than specified and possibly become uncalibrated.
${ }^{4}$ The AD7715 is production tested with $\mathrm{f}_{\text {CLKIN }}$ at 2.4576 MHz ( 1 MHz for some $\mathrm{I}_{\mathrm{DD}}$ tests). It is guaranteed by characterization to operate at 400 kHz .
${ }^{5}$ Specified using $10 \%$ and $90 \%$ points on waveform of interest.
${ }^{6}$ These numbers are measured with the load circuit of Figure 1 and defined as the time required for the output to cross the $\mathrm{V}_{\mathrm{OL}}$ or $\mathrm{V}_{\mathrm{OH}}$ limits.
${ }^{7}$ These numbers are derived from the measured time taken by the data output to change 0.5 V when loaded with the circuit of Figure 1 . The measured number is then extrapolated back to remove effects of charging or discharging the 100 pF capacitor. This means that the times quoted in the timing characteristics are the true bus relinquish times of the part and as such are independent of external bus loading capacitances.
${ }^{8} \overline{\mathrm{DRDY}}$ returns high after the first read from the device after an output update. The same data can be read again, if required, while $\overline{\mathrm{DRDY}}$ is high although care should be taken that subsequent reads do not occur close to the next output update.

ORDERING GUIDE


Figure 1. Load Circuit for Access Time and Bus Relinquish

| Model | AV <br> Sup <br> Suply | Temperature <br> Range | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD7715AN-5 | 5 V | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| AD7715AR-5 | 5 V | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16$ |
| AD7715AN-3 | 3 V | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| AD7715AR-3 | 3 V | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16$ |

* $\mathrm{N}=$ Plastic DIP; R = SOIC. For outline information see Package Information section.

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ABSOLUTE MAXIMUM RATINGS*
( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)

| $\mathrm{AV}_{\mathrm{DD}}$ to AGND | V to +7 V |
| :---: | :---: |
| $A V_{D D}$ to DGND | 0.3 V to +7 V |
| $\mathrm{DV}_{\mathrm{DD}}$ to AGND | -0.3 V to +7 V |
| $\mathrm{DV}_{\mathrm{DD}}$ to DGND | -0.3 V to +7 V |
| Analog Input Voltage to AGND | -0.3 V to $\mathrm{AV}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| Reference Input Voltage to AGND | -0.3 V to $\mathrm{AV}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| Digital Input Voltage to DGND | -0.3 V to $\mathrm{DV}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| Digital Output Voltage to DGND | -0.3 V to $\mathrm{DV}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| Operating Temperature Range |  |
| Commercial (A Version) | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Junction Temperature | $+150^{\circ} \mathrm{C}$ |

Plastic DIP Package, Power Dissipation ..... 450 mW
$\theta_{\mathrm{JA}}$ Thermal Impedance ..... $105^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature (Soldering, 10 sec ) ..... $+260^{\circ} \mathrm{C}$
SOIC Package, Power Dissipation ..... 450 mW
$\theta_{\mathrm{JA}}$ Thermal Impedance ..... $75^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature, Soldering
Vapor Phase ( 60 sec ) ..... $+215^{\circ} \mathrm{C}$
Infrared ( 15 sec ) ..... $+220^{\circ} \mathrm{C}$
Power Dissipation (Any Package) to $+75^{\circ} \mathrm{C}$ ..... 450 mW
*Stresses above those listed under "Absolute Maximum Ratings" may causepermanent damage to the device. This is a stress rating only and functionaloperation of the device at these or any other conditions above those listed in theoperational sections of this specification is not implied. Exposure to absolutemaximum rating conditions for extended periods may affect device reliability.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although these devices feature proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


## TERMINOLOGY

## INTEGRAL NONLINEARITY

This is the maximum deviation of any code from a straight line passing through the endpoints of the transfer function. The endpoints of the transfer function are zero scale (not to be confused with bipolar zero), a point 0.5 LSB below the first code transition ( $000 \ldots 000$ to $000 \ldots 001$ ) and full-scale, a point 0.5 LSB above the last code transition (111 . . 110 to 111 . ? 111). The error is expressed as a percentage of full scale.

## POSITIVE FULL-SCALE ERROR

Positive full-scale error is the deviation of the last code transition (111 . . . 110 to 111 . . 111) from the ideal AIN(+) voltage (AIN(-) $+\mathrm{V}_{\mathrm{REF}} / \mathrm{GAIN}-3 / 2 \mathrm{LSB}$ ). It applies to both unipolar and bipolar analog input ranges.

## UNIPOLAR OFFSET ERROR

Unipolar offset error is the deviation of the first code transition from the ideal $\operatorname{AIN}(+)$ voltage (AIN $(-)+0.5 \mathrm{LSB}$ ) when operating in the unipolar mode.

## BIPOLAR ZERO ERROR

This is the deviation of the midscale transition ( 0111 . . . 111 to 1000 . . . 000) from the ideal $\operatorname{AIN}(+$ ) voltage (AIN(-) 0.5 LSB) when operating in the bipolar mode.

## GAIN ERROR

This is a measure of the span error of the ADC. It includes fullscale errors but not zero-scale errors. For unipolar input ranges it is defined as (full-scale error-unipolar offset error) while for bipolar input ranges it is defined as (full-scale error-bipolar zero error).

## BIPOLAR NEGATIVE FULL-SCALE ERROR

This is the deviation of the first code transition from the ideal $\operatorname{AIN}(+)$ voltage (AIN(-) - V $\mathrm{REF} / \mathrm{GAIN}+0.5 \mathrm{LSB}$ ) when operating in the bipolar mode.

POSITIVE FULL-SCALE OVERRANGE
Positive full-scale overrange is the amount of overhead available to handle input voltages on $\operatorname{AIN}(+)$ input greater than $\operatorname{AIN}(-)+$ $V_{\text {REF }}$ GAIN (for example, noise peaks or excess voltages due to system gain errors in system calibration routines) without introducing errors due to overloading the analog modulator or overflowing the digital filter.

## NEGATIVE FULL-SCALE OVERRANGE

This is the amount of overhead available to handle voltages on AIN( + ) below AIN(-) - $\mathrm{V}_{\text {REF }} / \mathrm{GAIN}$ without overloading the analog modulator or overflowing the digital filter. Note that the analog input will accept negative voltage peaks even in the unipolar mode provided that $\operatorname{AIN}(+)$ is greater than $\operatorname{AIN}(-)$ and greater than AGND - 30 mV .

## OFFSET CALIBRATION RANGE

In the system calibration modes, the AD7715 calibrates its offset with respect to the analog input. The offset calibration range specification defines the range of voltages that the AD7715 can accept and still calibrate offset accurately.

## FULL-SCALE CALIBRATION RANGE

This is the range of voltages that the AD7715 can accept in the system calibration mode and still calibrate full scale correctly.

## INPUT SPAN

In system calibration schemes, two voltages applied in sequence to the AD7715's analog input define the analog input range. The input span specification defines the minimum and maximum input voltages from zero to full scale that the AD7715 can accept and still calibrate gain accurately.

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| Mnemonic | Function |
| :---: | :---: |
| SCLK | Serial Clock. Logic Input. An external serial clock is applied to this input to access serial data from the AD7715. This serial clock can be a continuous clock with all data transmitted in a continuous train of pulses. Alternatively, it can be a noncontinuous clock with the information being transmitted to the AD7715 in smaller batches of data. |
| MCLK IN | Master Clock signal for the device. This can be provided in the form of a crystal or external clock. A crystal can be tied across the MCLK IN and MCLK OUT pins. Alternatively, the MCLK IN pin can be driven with a CMOS-compatible clock and MCLK OUT left unconnected. The clock input frequency is nominally either 2.5 MHz or 1 MHz . |
| MCLK OUT | When the master clock for the device is a crystal, the crystal is connected between MCLK IN and MCLK OUT. Note, the on-chip clock signal is not available at this pin. |
| $\overline{\text { RESET }}$ | Logic Input. Active low input which resets the control logic, interface logic, digital filter and analog modulator of the part to power-on status. |
| AIN(+) | Analog Input. Positive input of the programmable gain differential analog input to the AD7715. |
| AIN(-) | Analog Input. Negative input of the programmable gain differential analog input to the AD7715. |
| $\mathrm{AV}_{\mathrm{DD}}$ | Analog Positive Supply Voltage, +3 V nominal (AD7715-3) or +5 V nominal (AD7715-5). |
| REF IN(-) | Reference Input. Negative input of the differential reference input to the AD7715. The REF IN(-) can lie anywhere between $A V_{D D}$ and $A G N D$ provided REF IN $(+)$ is greater than REF IN $(-)$. |
| REF IN(+) | Reference Input. Positive input of the differential reference input to the AD7715. The reference input is differential with the provision that REF IN $(+)$ must be greater than REF IN $(-)$. REF IN $(+)$ can lie anywhere between $\mathrm{AV}_{\mathrm{DD}}$ and AGND. |
| AGND | Ground reference point for analog circuitry, \% |
| $\overline{\mathrm{CS}}$ | Chip Select. Active low Logic Input used to select the AD7715. With this input hard-wired low, the AD7715 can operate in its three-wire interface mode with SCLK, DIN and DOUT used to interface to the device. $\overline{C S}$ can be used to select the device in systems with more than one device on the serial bus or as a frame synchronization signal in communicating with the AD7715. |
| $\overline{\text { DRDY }}$ | Logic Output. A logic low on this output indicates that a new output word is available from the AD7715 data register. The $\overline{\mathrm{DRDY}}$ pin will return high upon completion of a read operation of a full output word. If no data read has taken place, after an output update, the $\overline{\text { DRDY }}$ line will return high for $500 \times \mathrm{t}_{\mathrm{CLK}}$ IN cycles prior to the next output update. This gives an indication of when a read operation should not be attempted to avoid reading from the data register as it is being updated. $\overline{\mathrm{DRDY}}$ is also used to indicate when the AD7715 has completed its on-chip calibration sequence. |
| DOUT | Serial Data Output with serial data being read from the output shift register on the part. This output shift register can contain information from the calibration registers, mode register, communications register, filter selection registers or data register depending on the register selection bits of the communications register. |
| DIN | Serial Data Input with serial data being written to the input shift register on the part. Data from this input shift register is transferred to the calibration registers, mode register, communications register or filter selection registers depending on the register selection bits of the communications register. |
| DV ${ }_{\text {DD }}$ | Digital Supply Voltage, +3 V or +5 V nominal. |
| DGND | Ground reference point for digital circuitry. |

[^70]
## On-Chip Registers

The part contains four on-chip registers that can be accessed via the serial port on the part. The first of these is a communications register that decides whether the next operation is a read or write operation and also decides which register the read or write operation accesses The communication register also controls the standby mode and calibration modes of the part. The $\overline{\text { DRDY }}$ status is also available by reading from the communications register. All communication to any register on the device (including the data register) begins with a write to the communications register. The second register is a setup register that determines filter selection, gain setting and bipolar/unipolar operation. The third register is the data register from which the output data from the part is accessed. The final register is a test register which is accessed when testing the device. It is advised that the user does not attempt to access or change the contents
of the test register as it may lead to unspecified operation of the device. The registers are discussed in mode detail in the following sections.

## Communications Register (RS1, RS0 = 0, 0)

The communications register is an 8 -bit register from which data can either be read or to which data can be written. On power-up or after a $\overline{\text { RESET, the part is waiting for a write op- }}$ eration to the communications register. When the part has finished communicating with any of the other registers (either a read or write operation), it returns to the position of expecting a write to the communications register. This is the default state of the interface and in situations where the interface sequence is lost, if enough writes to the device (at least four bytes) take place with DIN high the part returns to its default state. Table I outlines the bit designations for the communications register.

Table I. Communications Register

| $0 / \overline{\mathrm{DRDY}}$ | 0 | RS 1 | RS 0 | $\mathrm{R} / \overline{\mathrm{W}}$ | STBY | MD1 | MD0 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |


| $0 / \overline{\text { DRDY }}$ | For a read operation, this bit provides the status of the $\overline{\mathrm{DRDY}}$ flag from the part. The status of this bit is the same as the $\overline{\mathrm{DRDY}}$ output pin. For a write operation, a 0 must be written to this bit so that the write operation will be recognized by the register. If a 1 is written to the bit, the interface does not clock itself on and the part continues to sample this bit location, effectively waiting for a obefore it will proceed to write any data to the communications register. |
| :---: | :---: |

$0 \quad$ For a write operation, a 0 must be written to this bit for correct operation of the part. Failure to do this will result in unspecified operation of the device. For a read operation, a 0 will be read back from this bit location.
RS1-RS0 Register Selection Bits. These bits select to which one of four on-chip registers the next read or write operation takes place as follows. When the read or write to the selected register is complete, the part returns to where it is waiting for a write operation to the communications register. It does not remain in a state where it will continue to access the selected register.

| RS1 | RS0 | Register | Register Size |
| :--- | :--- | :--- | :--- |
| 0 | 0 | Communications Register | 8 Bit |
| 0 | 1 | Setup Register | 8 Bit |
| 1 | 0 | Test Register | 8 Bit |
| 1 | 1 | Data Register | 16 Bit |


| $\mathrm{R} / \mathrm{W}$ |  | Read/Write Select. This bit selects whether the next operation is a read or write operation to the selected register. A 0 indicates a write cycle for the next operation to the appropriate register, while a 1 indicates a read operation from the appropriate register. |
| :---: | :---: | :---: |
| STBY |  | Standby. Writing a 1 to this bit puts the part in its standby or power-down mode. In this mode, the part consumes only $50 \mu \mathrm{~W}$ of power. The part retains its calibration and control word information when in STANDBY. Writing a 0 to this bit places the part in its normal operating mode. |
| MD1 | MD0 | Operating Mode |
| 0 | 0 | Normal Mode; this is the normal mode of operation of the device whereby the device is performing normal conversions. This is the default condition of these bits after power-on or RESET. |
| 0 | 1 | Self-Calibration; this activates self-calibration on the part. This is a one step calibration sequence and when complete the part returns to normal mode. The $\overline{\mathrm{DRDY}}$ output or bit indicates when this self-calibration is complete and a valid word is available in the data register. For this calibration type, the zero-scale calibration is done internally on shorted (zeroed) inputs and the full-scale calibration is done internally on $\mathrm{V}_{\mathrm{REF}}$. |
| 1 | 0 | Zero-Scale System Calibration; this activates zero-scale system calibration on the analog input. Calibration is performed on the analog input voltage provided at the analog input during this calibration sequence. The $\overline{\mathrm{DRDY}}$ output or bit indicates when this zero-scale calibration is complete and the part returns to normal mode. |
| 1 | 1 | Full-Scale System Calibration; this activates full-scale system calibration on the analog input. Calibration is performed on the analog input voltage provided at the analog input during this calibration sequence. Once again, $\overline{\mathrm{DRDY}}$ indicates when this full-scale calibration is complete. When this calibration is complete, the part returns to normal mode. |

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## AD7715

Setup Register (RS1, RS0 = 0, 1)
The setup register is an 8 -bit register from which data can either be read or to which data can be written. This register controls the setup which the device is to operate in such as the gain, output rate, unipolar/bipolar operation etc. Table II outlines the bit designations for the mode register.

Table II. Setup Register

| G1 | G0 | CLK | FS1 | FS0 | B/U | BUF | FSYNC |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |


| G2 | G1 | Gain Setting |
| :--- | :--- | :--- |
| 0 | 0 | 1 |
| 0 | 1 | 2 |
| 1 | 0 | 32 |
| 1 | 1 | 128 |

CLK Clock Bit. This bit should be set in accordance with the operating frequency of the AD7715. If the device has a master clock frequency of 2.4576 MHz , then this bit should be set to a 0 . If the device has a master clock frequency of 1 MHz , then this bit should be set to a 1 . This bit sets up the correct scaling currents for a given master clock and also chooses (along with FS1 and FS0) the output update rate for the device. If this bit is not set correctly for the master clock frequency of the device, then the device may not operate to specification.
FS1, FS0 Filter Selection Bits. Along with the CLK bit, FS1 and FSO determine the output update rate, filter first notch and -3 dB frequency as below. The on-chip digital filter provides a $\operatorname{Sinc}^{3}$ (or $(\operatorname{Sin} \mathrm{x} / \mathrm{x})^{3}$ ) filter response. In association with the gain selection, it also determines the output noise (and hence the effective resolution) of the device. Changing the filter notch frequency, as well as the selected gain, impacts resolution. Tables III through VI show the effect of the filter notch frequency and gain on the output noise and effective resolution of the part. The output data rate (or effective conversion time) for the device is equal to the frequency selected for the first notch of the filter. For example, if the first notch of the filter is selected at 50 Hz , then a new word is available at a 50 Hz rate or every 20 ms . If the first notch is at 500 Hz , a new word is available every 2 ms .
The settling time of the filter to a full-scale step input change is worst case $4 \times 1 /$ (output data rate). For example, with the first filter notch at 50 Hz , the settling time of the filter to a full-scale step input change is 80 ms max . If the first notch is at 500 Hz , the settling time of the filter to a full-scale input step is 8 ms max. This settling-time can be reduced to $3 \times 1$ (output data rate) by synchronizing the step input change to a reset of the digital filter. In other words, if the step input takes place with the $\overline{\text { RESET }}$ input low, the settling time will be $3 \times 1$ /(output data rate) from when RESET returns high.

| CLK | FS1 | FSO | Output Update Rate | -3 dB Filter Cutoff |
| :--- | :--- | :--- | :--- | :--- |
| 0 | 0 | 0 | 50 Hz | 13.1 Hz |
| 0 | 0 | 1 | 60 Hz | 15.7 Hz |
| 0 | 1 | 0 | 250 Hz | 65.5 Hz |
| 0 | 1 | 1 | 500 Hz | 121 Hz |
| 1 | 0 | 0 | 20 Hz | 5.24 Hz |
| 1 | 0 | 1 | 25 Hz | 6.55 Hz |
| 1 | 1 | 0 | 100 Hz | 26.2 Hz |
| 1 | 1 | 1 | 200 Hz | 52.4 Hz |

Bipolar/Unipolar Operation. A 0 in this bit selects bipolar operation. This is the default (Power-On or $\overline{\text { RESET }}$ ) status of this bit. A 1 in this bit selects unipolar operation.
FSYNC Filter Synchronization. When this bit is high, the nodes of the digital filter, the filter control logic and the calibration control logic are reset and the analog modulator is also held in its reset state. When this bit goes low, valid data is available in $3 \times 1$ (output update rate), i.e., the settling time of the filter.

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Test Register ( $\mathbf{R S} 1, \mathbf{R S} 0=1,0$ )
The part contains a test register which is used in testing the device. The user is advised not to change the status of any of the bits in this register from the default (Power-On or RESET) status of all 0 s as the part will be placed in one of its test modes and will not operate correctly. If the part enters one of its test modes, exercising RESET will exit the part from the mode.
Data Register (RS1, RS0 $=1,1$ )
The data register on the part is a read-only register which contains the most up-to-date conversion result from the part. The register is 16 bits wide. If an attempt is made to write to this register, the data will not actually be written to any location of the part.

## OUTPUT NOISE

AD7715-5
Table III shows the AD7715-5 output rms noise for the selectable notch and -3 dB frequencies for the part, as selected by FS1 and FS0 (see above). The numbers given are for the bipolar input ranges with a $\mathrm{V}_{\mathrm{REF}}$ of +2.5 V . These numbers are typical and are generated at an analog input voltage of 0 V and for the BUF bit of the setup register $=0$. Noise numbers for the two lower notch settings will typically be $10 \%$ higher than those in Table III for BUF Bit $=1$.
Table IV meanwhile shows the output peak-to-peak noise for the selectable notch and -3 dB frequencies for the part. It is important to note that these numbers represent the resolution for which there will be no code flicker. They are not calculated based on rms noise but on peak-to-peak noise. The numbers given are for the bipolar input ranges with a $\mathrm{V}_{\text {REF }}$ of +2.5 V and for the BUF bit of the setup register $=0$. These numbers are typical, are generated at an analog input voltage of 0 V and are rounded to the nearest LSB.

Table III. Output RMS Noise vs. Gain and Output Update Rate for AD7715-5
Filter First Notch \& O/P Data Rate -3 dB Frequency Typical Output RMS Noise in $\mu \mathrm{V}$


Table IV. Effective (Peak-to-Peak) Resolution vs. Gain and Output Update Rate for AD7715-5 Filter First Notch \& O/P Data Rate -3 dB Frequency Typical Effective Resolution in Bits

| $\begin{aligned} & \text { MCLK IN = } \\ & 2.4576 \mathrm{MHz} \end{aligned}$ | $\begin{aligned} & \text { MCLK IN = } \\ & 1 \mathrm{MHz} \end{aligned}$ | $\begin{aligned} & \text { MCLK IN = } \\ & 2.4576 \mathrm{MHz} \end{aligned}$ | $\begin{aligned} & \text { MCLK IN = } \\ & 1 \mathrm{MHz} \end{aligned}$ | GAIN = 1 | GAIN $=2$ | GAIN = 32 | GAIN $=128$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 50 Hz | 20 Hz | 13.1 Hz | 5.24 Hz | 16 | 16 | 16 | 14 |
| 60 Hz | 25 Hz | 15.72 Hz | 6.55 Hz | 16 | 16 | 16 | 14 |
| 250 Hz | 100 Hz | 65.5 Hz | 26.2 Hz | 12 | 12 | 12 | 12 |
| 500 Hz | 200 Hz | 131 Hz | 52.4 Hz | 10 | 10 | 10 | 10 |

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## AD7715

## OUTPUT NOISE

## AD7715-3

Table V shows the AD7715-3 output rms noise for the selectable notch and -3 dB frequencies for the part, as selected by FS1 and FS0 (see above). The numbers given are for the bipolar input ranges with a $\mathrm{V}_{\mathrm{REF}}$ of +1.25 V and for the BUF bit of the setup register $=0$. These numbers are typical and are generated at an analog input voltage of 0 V . Noise numbers for the two lower notch settings will typically be $10 \%$ higher than those in Table V for BUF Bit $=1$.

Table VI meanwhile shows the output peak-to-peak noise for the selectable notch and -3 dB frequencies for the part. It is important to note that these numbers represent the resolution for which there will be no code flicker. They are not calculated based on rms noise but on peak-to-peak noise. The numbers given are for the bipolar input ranges with a $\mathrm{V}_{\mathrm{REF}}$ of +1.25 V and for the BUF bit of the setup register $=0$. These numbers are typical, are generated at an analog input voltage of 0 V and are rounded to the nearest LSB.

Table V. Output RMS Noise vs. Gain and Output Update Rate for AD7715-3
Filter First Notch \& O/P Data Rate
-3 dB Frequency
Typical Output RMS Noise in $\mu \mathrm{V}$

| $\begin{aligned} & \text { MCLK IN = } \\ & \text { 2.4576 MHz } \end{aligned}$ | $\begin{aligned} & \text { MCLK IN = } \\ & 1 \mathrm{MHz} \end{aligned}$ | $\begin{aligned} & \text { MCLK IN = } \\ & 2.4576 \mathrm{MHz} \end{aligned}$ | $\begin{aligned} & \text { MCLK IN = } \\ & 1 \mathrm{MHz} \end{aligned}$ | GAIN $=1$ | GAIN = 2 | GAIN = 32 | GAIN $=128$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 50 Hz | 20 Hz | 13.1 Hz | 5.24 Hz | 7.0 | 3.5 | 0.5 | 0.4 |
| 60 Hz | 25 Hz | 15.72 Hz | 6.55 Hz | 8.2 | 4.1 | 0.5 | 0.4 |
| 250 Hz | 100 Hz | 65.5 Hz | 26.2 Hz | 53 | 28 | 3.5 | 1.4 |
| 500 Hz | 200 Hz | 131 Hz | 52.4 Hz | 240 | 150 | 14 | 8 |

Table VI. Effective (Peak-to-Peak) Resolution vs. Gain and Output Update Rate for AD7715-3 Filter First Notch \& O/P Data Rate $\mathbf{- 3} \mathbf{d B}$ Frequency $\quad$ Typical Effective Resolution in Bits


## CIRCUIT DESCRIPTION

The AD7715 is a sigma-delta A/D converter with on-chip digital filtering, intended for the measurement of wide dynamic range, low frequency signals such as those in industrial control or process control applications. It contains a sigma-delta (or chargebalancing) ADC, a calibration microcontroller with on-chip static RAM, a clock oscillator, a digital filter and a bidirectional serial communications port. The part consumes only $500 \mu \mathrm{~A}$ of power supply current, making it ideal for battery-powered or loop-powered instruments. The part comes in two versions, the AD7715-5 which is specified for operation from a +5 V analog supply ( $\mathrm{AV} \mathrm{VD}_{\mathrm{D}}$ ) and the $\mathrm{AD} 7715-3$ which is specified for operation from $\mathrm{a}+3 \mathrm{~V}$ analog supply. The AD7715-5 can be operated with a digital supply ( $\mathrm{DV}_{\mathrm{DD}}$ ) voltage of +3 V or +5 V .
The part contains a programmable gain fully differential analog input channel. The selectable gains on this input are 1, 2, 32 and 128 allowing the part to accept unipolar signals of between 0 mV to +20 mV and 0 V to +2.5 V or bipolar signals in the range from $\pm 20 \mathrm{mV}$ to $\pm 2.5 \mathrm{~V}$ when the reference input voltage equals +2.5 V . With a reference voltage of +1.25 V , the input ranges are from 0 mV to +10 mV to 0 V to +1.25 V in unipolar mode and from $\pm 10 \mathrm{mV}$ to $\pm 1.25 \mathrm{~V}$ in bipolar mode.

The input signal to the analog input is continuously sampled at a rate determined by the frequency of the master clock, MCLK IN, and the selected gain. A charge-balancing A/D converter (Sigma-Delta Modulator) converts the sampled signal into a digital pulse train whose duty cycle contains the digital information. The programmable gain function on the analog input is also incorporated in this sigma delta modulator with the input sampling frequency being modified to give the higher gains. A $\operatorname{sinc}^{3}$ digital low-pass filter processes the output of the sigmadelta modulator and updates the output register at a rate determined by the first notch frequency of this filter. The output data can be read from the serial port randomly or periodically at any rate up to the output register update rate. The first notch of this digital filter (and hence its -3 dB frequency) can be programmed via the mode register bits FS0 and FS1. With a master clock frequency of 2.4576 MHz , the programmable range for this first notch frequency is from 50 Hz to 500 Hz giving a programmable range for the -3 dB frequency of 13.1 Hz to 131 Hz . With a master clock frequency of 1 MHz , the programmable range for this first notch frequency is from 20 Hz to 200 Hz giving a programmable range for the -3 dB frequency of 5.24 Hz to 52.4 Hz .

[^71]
## DIGITAL INTERFACE

The part's serial interface can operate in three-wire mode by tying the $\overline{\mathrm{CS}}$ input low. In this case, the SCLK, DIN and DOUT lines are used to communicate with the part and the status of $\overline{\text { DRDY }}$ can be obtained by interrogating the MSB of the communications register. $\overline{\mathrm{CS}}$ can be used to decode the part in systems where a number of parts are connected to the serial bus. Figures 2 and 3 show timing diagrams for interfacing to the part with $\overline{\mathrm{CS}}$ used to decode the part. Figure 2 is for a read operation from the part's output shift register while Figure 3 shows a write operation to the input shift register.


Figure 2. Read Cycle Timing Diagram


Figure 3. Write Cycle Timing Diagram

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## FEATURES

22-Bit Sigma-Delta ADC
Dynamic Range of $105 \mathrm{~dB}(\mathbf{1 4 6} \mathrm{~Hz}$ Input) $\pm 0.003 \%$ Integral Nonlinearity
On-Chip Low-Pass Digital Filter
Cutoff Programmable from 584 Hz to $\mathbf{3 6 . 5} \mathrm{Hz}$ Linear Phase Response
Five Line Serial I/O
Twos Complement Coding
Easy Interface to DSPs and Microcomputers
Software Control of Filter Cutoff
$\pm 5$ V Supply
Low Power Operation: 50 mW

## APPLICATIONS

## Biomedical Data Acquisition

## ECG Machines

EEG Machines
Process Control
High Accuracy Instrumentation
Seismic Systems

## GENERAL DESCRIPTION

The AD7716 is a signal processing block for data acquisition systems. It is capable of processing four channels with bandwidths of up to 584 Hz . Resolution is 22 bits and the usable dynamic range varies from 111 dB with an input bandwidth of 36.5 Hz to 99 dB with an input bandwidth of 584 Hz .

The device consists of four separate $A / D$ converter channels that are implemented using sigma-delta technology. Sigma-delta ADCs include on-chip digital filtering and, thus, the system filtering requirements are eased.
Three address pins program the device address. This allows a data acquisition system with up to 32 channels to be set up in a simple fashion. The output word from the device contains 32 bits of data. One bit is determined by the state of the $\mathrm{D}_{\text {IN }} 1$ input and may be used, for example, in an ECG system with an external pacemaker detect circuit to indicate that the output word is invalid because of the presence of a pacemaker pulse.

## FUNCTIONAL BLOCK DIAGRAM



There are 22 bits of data corresponding to the analog input. Two bits contain the channel address and 3 bits are the device address. Thus, each channel in a 32 -channel system would have a discrete 5-bit address. The device also has a CASCOUT pin and a CASCIN pin that allow simple networking of multiple devices.
The on-chip control register is programmed using the SCLK, SDATA and TFS pins. Three bits of the Control Register set the digital filter cutoff frequency for the device. Selectable frequencies are $584 \mathrm{~Hz}, 292 \mathrm{~Hz}, 146 \mathrm{~Hz}, 73 \mathrm{~Hz}$ and 36.5 Hz . A further 2 bits appear as outputs $\mathrm{D}_{\text {OUT }} 1$ and $\mathrm{D}_{\text {OUT }} 2$ and can be used for controlling calibration at the front end. The device is available in a 44-pin PQFP (Plastic Quad Flatpack) and 44-pin PLCC.
$\pm 5 \%$; $\mathrm{AV}_{\text {SS }}=-5 \mathrm{~V} \pm 5 \%$; AGND $=\mathrm{DGND}=0 \mathrm{~V} ; \mathrm{V}_{\text {REF }}=2.5 \mathrm{~V}$; Filter Cutoff $=146 \mathrm{~Hz}$; Noise Measurement Bandwidth $=146 \mathrm{~Hz}$;
$A_{I N}$ Source Resistance $=750 \Omega^{2}$ with 1 nF to AGND at each $A_{I N} \cdot \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$, unless otherwise noted.)

| Parameter | B Version | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: |
| STATIC PERFORMANCE <br> Resolution <br> Integral Linearity Error <br> Gain Error <br> Gain Match Between Channels <br> Gain TC <br> Offset Error <br> Offset Match Between Channels <br> Offset TC <br> Noise | $\begin{aligned} & 22 \\ & 0.003 \\ & 0.006 \\ & 1 \\ & 0.5 \\ & 30 \\ & 0.2 \\ & 0.1 \\ & 4 \\ & 11 \end{aligned}$ | Bits <br> \% FSR typ <br> \% FSR max <br> \% FSR max <br> \% FSR max <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ <br> \% FSR max <br> \% FSR max <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ typ <br> $\mu \mathrm{V}$ rms max | Guaranteed No Missed Codes to 21 Bits $^{3}$ <br> See Table I for Typical Noise Performance vs. Programmed Cutoff Frequency |
| DYNAMIC PERFORMANCE <br> Sampling Rate <br> Output Update Rate <br> Filter Cutoff Frequency <br> Settling Time <br> Usable Dynamic Range ${ }^{4}$ <br> Total Harmonic Distortion <br> Absolute Group Delay ${ }^{3}$ <br> Differential Group Delay ${ }^{3}$ <br> Channel-to-Channel Isolation | $\begin{aligned} & \mathrm{f}_{\mathrm{CLKIN}} / 14 \\ & \mathrm{f}_{\mathrm{CLKIN}} /\left(14 \times 256 \times 2^{\mathrm{N}}\right) \\ & \mathrm{f}_{\mathrm{CLKIN}} /\left(3.81 \times 14 \times 256 \times 2^{\mathrm{N}}\right) \\ & \left(3 \times 14 \times 256 \times 2^{\mathrm{N}} / \mathrm{f}_{\mathrm{CLKIN}}\right) \\ & \text { See Table } \mathrm{I} \\ & -90 \\ & -100 \\ & \left(3 \times 14 \times 256 \times 2^{\mathrm{N}}\right) / 2 \mathrm{f}_{\mathrm{CLKIN}} \\ & 10 \\ & -85 \end{aligned}$ | dB typ <br> dB typ <br> ns typ <br> dB typ | 570 kHz for $\mathrm{f}_{\text {CLKIN }}=8 \mathrm{MHz}$ <br> N Is Decimal Equivalent of FC2, FC1, FC0 in Control Register <br> Input Frequency $=35 \mathrm{~Hz}$ $\mathrm{A}_{\mathrm{IN}}= \pm 10 \mathrm{mV} \text { p-p }$ <br> Feedthrough from Any One Channel to the Other Three, with 35 Hz Full-Scale Sine Wave Applied to that Channel |
| ANALOG INPUT <br> Input Range <br> Input Capacitance <br> Input Bias Current | $\begin{aligned} & \pm 2.5 \\ & 10 \\ & 1 \end{aligned}$ | Volts <br> pF typ <br> nA typ |  |
| LOGIC INPUTS <br> $\mathrm{V}_{\text {INH }}$, Input High Voltage <br> $V_{\text {INL }}$, Input Low Voltage <br> $\mathrm{I}_{\mathrm{IN}}$, Input Current SDATA, $\overline{R F S}$ TFS <br> All Other Inputs $\mathrm{C}_{\mathrm{IN}}$, Input Capacitance ${ }^{3}$ | $\begin{aligned} & 2.4 \\ & 0.8 \\ & +10 /-130 \\ & +10 /-650 \\ & \pm 10 \\ & 10 \end{aligned}$ | V min <br> V max <br> $\mu \mathrm{A} \max$ <br> $\mu \mathrm{A}$ max <br> $\mu \mathrm{A}$ max <br> pF max | Internal $50 \mathrm{k} \Omega$ Pull-Up Resistors Internal $10 \mathrm{k} \Omega$ Pull-Up Resistor |
| LOGIC OUTPUTS <br> $\mathrm{V}_{\mathrm{OH}}$, Output High Voltage <br> $V_{\text {OL }}$ Output Low Voltage | $\begin{aligned} & 2.4 \\ & 0.4 \\ & \hline \end{aligned}$ | V min <br> V max | $\left\|\mathrm{I}_{\text {OUT }}\right\| \leq 40 \mu \mathrm{~A}$ <br> $\left\|\mathrm{I}_{\text {OUT }}\right\| \leq 1.6 \mathrm{~mA}$ |
| POWER SUPPLIES <br> Reference Input <br> AV ${ }_{\text {DD }}$ <br> $D V_{D D}$ <br> $\mathrm{AV}_{\mathrm{Ss}}$ <br> $\mathrm{I}_{\mathrm{DD}}$ <br> IS <br> Power Consumption <br> Power Supply Rejection ${ }^{5}$ | $\begin{aligned} & 2.4 / 2.6 \\ & 4.75 / 5.25 \\ & 4.75 / 5.25 \\ & -4.75 /-5.25 \\ & 7.5 \\ & 2.5 \\ & 50 \\ & -70 \end{aligned}$ | $\mathrm{V} \min / \mathrm{V} \max$ <br> $\mathrm{V} \min / \mathrm{V}_{\max }$ <br> $\mathrm{V} \min / \mathrm{V} \max$ <br> $\mathrm{V} \min / \mathrm{V} \max$ <br> mA max <br> mA max <br> mW max <br> dB typ | $\begin{aligned} & 4.8 \mathrm{~mA} \text { typ } \\ & 1.8 \mathrm{~mA} \text { typ } \\ & 35 \mathrm{~mW} \text { typ } \end{aligned}$ |

## NOTES

${ }^{1}$ Operating temperature ranges as follows: B Version; $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.
${ }^{2}$ The $\mathrm{A}_{\text {IN }}$ pins present a very high impedance dynamic load which varies with clock frequency.
${ }^{3}$ Guaranteed by design and characterization. Digital filter has linear phase.
${ }^{4}$ Usable dynamic range is guaranteed by measuring noise and relating this to the full-scale input range.
${ }^{5} 100 \mathrm{mV}$ p-p, 120 Hz sine wave applied to each supply.
Specifications subject to change without notice.

Table I. Typical Usable Dynamic Range, RMS Noise and Filter Settling Time vs. Filter Cutoff Frequency

| $\mathbf{N}$ | Programmed Cutoff <br> Frequency (Hz) | Output Update <br> Rate (Hz) | Usable Dynamic <br> Range (dB) | RMS Noise <br> $(\mu \mathbf{V})$ | Filter Settling Time to <br> $\pm \mathbf{0 . 0 0 0 7 \% ~ F S}(\mathbf{m s})$ | Absolute Group <br> Delay (ms) |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| 0 | 584 | 2232 | 99 | 21 | 1.35 | 0.675 |
| 1 | 292 | 1116 | 102 | 14 | 2.7 | 1.35 |
| 2 | 146 | 558 | 105 | 10 | 5.4 | 2.7 |
| 3 | 73 | 279 | 108 | 7 | 10.8 | 5.4 |
| 4 | 36.5 | 140 | 111 | 5 | 10.8 |  |

NOTE
Usable Dynamic Range is defined as the ratio of the rms full-scale reading (sine wave input) to the rms noise of the converter.

## CONTROL REGISTER TIMING CHARACTERISTICS ${ }^{1,2}{ }^{2} \mathrm{AVV}_{00}=D V_{D 0}=+5 V \pm 5 \% ; \mathrm{Av}_{S S}=-5 \mathrm{~V} \pm 5 \% ;$ AGNO $=$

 DGND $=0 \mathrm{~V}$; $\mathrm{f}_{\text {cluxim }}=8 \mathrm{MHz}$; Input Levels: Logic $0=0 \mathrm{~V}$, Logic $1=\mathrm{DV}_{\text {D0 }}$; unless otherwise noted)| Parameter | Limit at $\mathbf{T}_{\text {MIN }}, \mathbf{T}_{\text {MAX }}$ <br> $(B$ Version) | Units | Conditions/Comments |
| :--- | :--- | :--- | :--- |
| $\mathrm{t}_{1}$ | $1 / f_{\text {CLKIN }}$ | ns min | SCLK Period |
| $\mathrm{t}_{2}$ | 77 | ns min | SCLK Width |
| $\mathrm{t}_{3}$ | 30 | ns min | TFS Setup Time |
| $\mathrm{t}_{4}$ | 20 | ns min | SDATA Setup Time |
| $\mathrm{t}_{5}$ | 10 | ns min | SDATA Hold Time |
| $\mathrm{t}_{6}$ | 20 | ns min | TFS Hold Time |

NOTES
${ }^{1}$ Sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance. All input signals are specified with $\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of 5 V$)$ and timed from a voltage level of 1.6 V .
${ }^{2}$ See Figure 2.
${ }^{3}$ CLKIN Duty Cycle range is $40 \%$ to $60 \%$.


Figure 1. Load Circuit for Access Time and Bus Relinquish Time


Figure 2. Control Register Timing Diagram

MASTER MODE TIMING CHARACTERISTICS ${ }^{1,2}\left({ }^{2} V_{D D}=D V_{D D}=+5 \mathrm{~V} \pm 5 \% ; A V_{S S}=-5 \mathrm{~V} \pm 5 \% ; A G N D=D G N D=0 \mathrm{~V}\right.$;
$\mathrm{f}_{\text {clikin }}=8 \mathrm{MHz}$; Input Levels: Logic $0=0 \mathrm{~V}$, Logic $1=\mathrm{DV}_{\text {D0 }}$; unless otherwise noted)

| Parameter | Limit at $\mathrm{T}_{\mathrm{MIN}}, \mathrm{T}_{\mathrm{MAX}}$ (B Version) | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: |
| $\mathrm{f}_{\text {CLKIN }}{ }^{3,4}$ | 400 | kHz min | CLKIN Frequency |
|  | 8 | MHz max |  |
| $\mathrm{tr}_{5}{ }^{5}$ | 40 | ns max | Digital Output Rise Time. Typically 20 ns |
| $t_{f}^{5}$ | 40 | ns max | Digital Output Fall Time. Typically 20 ns |
| $\mathrm{t}_{7}$ | $1 / \mathrm{f}_{\text {CLKIN }}$ | ns min | CASCIN Pulse Width |
| $\mathrm{t}_{8}$ | 1/f ${ }_{\text {CLKIN }}$ | $n \mathrm{~ns}$ min | CASCIN to DRDY Setup Time |
| $\mathrm{t}_{9}$ | $1 / 2 \mathrm{f}_{\text {CLKIN }}+30$ | ns max | $\overline{\text { DRDY Low to SCLK Low Delay }}$ |
| $\mathrm{t}_{10}$ | 50 | ns max | CLKIN High to $\overline{\text { DRDY }}$ Low, SCLK Active, $\overline{\mathrm{RFS}}$ Active |
| $\mathrm{t}_{11}$ | 40 | ns max | CLKIN High to SCLK High Delay |
| $\mathrm{t}_{12}$ | 50 | ns min | SCLK Width |
| $\mathrm{t}_{13}$ | $1 / \mathrm{f}_{\text {CLKIN }}$ | ns | SCLK Period |
| $\mathrm{t}_{14}$ | 40 | ns max | SCLK High to $\overline{\text { RFS }}$ High Delay |
| $\mathrm{t}_{15}$ | 1/f $\mathrm{f}_{\text {CLKIN }}$ | ns | $\overline{\mathrm{RFS}}$ Pulse Width |
| $\mathrm{t}_{16}{ }^{6}$ | 45 | ns max | SCLK High to SDATA Valid Delay |
| $\mathrm{t}_{17}{ }^{7}$ | $1 / 2 \mathrm{f}_{\text {CLKIN }}+50$ | ns max | SCLK Low to SDATA High Impedance Delay |
|  | $1 / 2 \mathrm{f}_{\text {CLKIN }}+10$ | ns min |  |
| $\mathrm{t}_{18}$ | $1 / 2 \mathrm{f}_{\text {CLKIN }}+60$ | ns max | CLKIN High to $\overline{\text { DRDY }}$ High Delay |
| $\mathrm{t}_{19}$ | 50 | ns max | CLKIN High to $\overline{\text { RFS }}$ High Impedance, SCLK High Impedance |
|  | 20 | ns min |  |
| $\mathrm{t}_{20}$ | $1 / 2 \mathrm{f}_{\text {CLKIN }}+50$ | ns max | SCLK Low to CASCOUT High Delay |
| $\mathrm{t}_{21}$ | $2 / \mathrm{f}_{\text {CLKIN }}$ | ns | CASCOUT Pulse Width |

## NOTES

${ }^{1}$ Sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance. All input signals are specified with $\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of 5 V$)$ and timed from a voltage level of 1.6 V . ${ }^{2}$ See Figures 1 and 3.
${ }^{3}$ CLKIN duty cycle range is $40 \%$ to $60 \%$.
${ }^{4}$ The AD7716 is production tested with $\mathrm{f}_{\text {CLKIN }}$ at 8 MHz in the slave mode. It is guaranteed by characterization to operate at 400 kHz and 8 MHz in master mode.
${ }^{5}$ Specified using $10 \%$ and $90 \%$ points on waveform of interest.
${ }^{6} \mathrm{t}_{16}$ is measured with the load circuit of Figure 1 and defined as the time required for an output to cross 0.8 V or 2.4 V .
${ }^{7} \mathrm{t}_{17}$ is derived from the measured time taken by the data outputs to change 0.5 V when loaded with the circuit of Figure 1 . The measured number is then extrapolated back to remove the effects of charging or discharging the 100 pF capacitor. This means that the time quoted in the timing characteristics is the true bus relinquish time of the part and as such is independent of external bus loading capacitances.


Figure 3. Master Mode Timing Diagram

$\mathrm{f}_{\text {clexin }}=8 \mathrm{MHz}$; Input Levels: Logic $0=0 \mathrm{~V}$, Logic $1=\mathrm{DV}_{\text {Do }}$; unless otherwise noted)

| Parameter | (B Version) | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: |
| $\mathrm{f}_{\text {CLKIN }}{ }^{3,4}$ | 400 8 | kHz min MHz max | CLKIN Frequency |
| $\mathrm{tr}_{\mathrm{r}_{5}}$ | 40 | ns max | Digital Output Rise Time. Typically 20 ns |
| $\mathrm{t}_{\mathrm{f}}{ }^{5}$ | 40 | ns max | Digital Output Fall Time. Typically 20 ns |
| $\mathrm{t}_{23}$ | $1 / \mathrm{f}_{\text {CLKIN }}$ | ns min | CASCIN Pulse Width |
| $\mathrm{t}_{24}$ | 50 | ns min | SCLK Width |
| $\mathrm{t}_{25}$ | 125 | ns min | SCLK Period |
| $\mathrm{t}_{26}$ | $1 / \mathrm{f}_{\text {CLKIN }}+30$ | ns min | CASCIN High to $\overline{\text { RFS }}$ Setup Time |
| $\mathrm{t}_{27}$ | 30 | ns min | $\overline{\mathrm{RFS}}$ Low to SCLK High Setup Time |
| $\mathrm{t}_{28}{ }^{6}$ | 50 | ns max | SCLK High to SDATA Valid Delay |
| $\mathrm{t}_{29}{ }_{7}$ | 50 | ns min | $\overline{\text { RFS }}$ Hold Time After SCLK High |
| $\mathrm{t}_{30}{ }^{7}$ | 50 | ns max | SCLK High to SDATA High Impedance Delay |
|  | 0 | $\mathrm{ns} \min$ |  |
| $\mathrm{t}_{31}$ | 60 | ns max | SCLK High to CASCOUT High Delay. |
| $\mathrm{t}_{32}$ | $2 / \mathrm{f}_{\text {CLKIN }}$ | ns max | CASCOUT Pulse Width |

## NOTES

${ }^{1}$ Sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance. All input signals are specified with $\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of 5 V$)$ and timed from a voltage level of 1.6 V . ${ }^{2}$ See Figures 1 and 4.
${ }^{3}$ CLKIN duty cycle range is $40 \%$ to $60 \%$.
${ }^{4}$ The AD7716 is production tested with $\mathrm{f}_{\text {CLKIN }}$ at 8 MHz in the slave mode. It is guaranteed by characterization to operate at 400 kHz .
${ }^{5}$ Specified using $10 \%$ and $90 \%$ points on waveform of interest.
${ }^{6} \mathrm{t}_{28}$ is measured with the load circuit of Figure 1 and defined as the time required for an output to cross 0.8 V or 2.4 V .
${ }^{7} \mathrm{t}_{30}$ is derived from the measured time taken by the data outputs to change 0.5 V when loaded with the circuit of Figure 1 . The measured number is then extrapolated back to remove the effects of charging or discharging the 100 pF capacitor. This means that the time quoted in the timing characteristics is the true bus relinquish time of the part and as such is independent of external bus loading capacitances.


Figure 4. Slave Mode Timing Diagram

| ABSOLUTE MAXIMUM RATINGS ${ }^{1}$ |  |
| :---: | :---: |
| ( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted) |  |
| $A V_{D D}$ to AGND | -0.3 V to +7 V |
| $\mathrm{AV}_{\text {ss }}$ to AGND | +0.3 V to -7 V |
| AGND to DGND | -0.3 V to +0.3 V |
| $\mathrm{AV}_{\mathrm{DD}}$ to $\mathrm{DV}_{\mathrm{DD}}$ | -0.3 V to +0.3 V |
| Analog Inputs to AGND | $\mathrm{AV}_{\mathrm{SS}}-0.3 \mathrm{~V}$ to $\mathrm{AV}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| $\mathrm{V}_{\text {REF }}$ to AGND | $\mathrm{AV}_{S S}-0.3 \mathrm{~V}$ to $\mathrm{AV}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| Digital Inputs to DGND ${ }^{2}$ | -0.3 V to $\mathrm{DV}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| Digital Outputs to DGND | -0.3 V to $\mathrm{DV}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| Operating Temperature Range |  |
| Commercial Plastic (B Versions) | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |

PQFP Package, Power Dissipation ..... 450 mW
$\theta_{\mathrm{JA}}$ Thermal Impedance ..... $95^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature, Soldering
Vapor Phase ( 60 sec ) ..... $+215^{\circ} \mathrm{C}$
Infrared (15 sec) ..... $+220^{\circ} \mathrm{C}$
PLCC Package, Power Dissipation ..... 500 mW
$\theta_{\mathrm{JA}}$ Thermal Impedance ..... $55^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature, Soldering
Vapor Phase ( 60 sec ) ..... $+215^{\circ} \mathrm{C}$
Infrared ( 15 sec ) ..... $+220^{\circ} \mathrm{C}$
NOTES
${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ Transient currents of up to 100 mA will not cause SCR latch-up.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although these devices feature proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


PQFP PINOUT


PLCC PINOUT


NC $=$ NO CONNECT

## ORDERING GUIDE

| Model | Temperature <br> Range | Output Noise <br> (Filter: $146 ~ H z)$ | Package <br> Option $^{\star}$ |
| :--- | :--- | :--- | :--- |
| AD7716BP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $11 \mu \mathrm{~V} \mathrm{rms}$ | $\mathrm{P}-44$ |
| AD7716BS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $11 \mu \mathrm{~V} \mathrm{rms}$ | $\mathrm{S}-44$ |

*P = PLCC (Plastic Leaded Chip Carrier); S = PQFP (Plastic Quad Flatpack). For outline information see Package Information section.

| Pin | Description |
| :---: | :---: |
| $\mathrm{AV}_{\text {DD }}$ | Analog Positive Supply, +5 V Nominal. This supplies +ve power to the analog modulators. $\mathrm{AV}_{\mathrm{DD}} \& \mathrm{DV}_{\mathrm{DD}}$ must be tied together externally. |
| DV DD | Digital Positive Supply, +5 V Nominal. This supplies +ve power to the digital filter and input/output registers. |
| $\mathrm{AV}_{\text {ss }}$ | Analog Negative Supply, -5 V nominal. This supplies -ve power to the analog modulators. |
| RESET | A high pulse on this input pin synchronizes the sampling point on the four input channels. It can be used in a multichannel system to ensure simultaneous sampling. This also resets the digital interface to a known state. |
| A0-A2 | The three address input pins, A0, A1 and A2 give the device a unique address. This information is contained in the output data stream from the device. |
| CLKIN | Clock Input for External Clock. |
| CLKOUT | Clock Output which is used to generate an internal master clock by connecting a crystal between CLKOUT and CLKIN. If an external clock is used then CLKOUT is not connected. |
| MODE | This digital input determines the device interface mode. If it is hardwired low, then the Master Mode interface is enabled whereas if it is high, the Slave Mode interface is enabled. |
| CASCIN | This is an active-high, level-triggered digital input which is used to enable the output data stream. This input may be used to cascade several devices in a multichannel system. |
| CASCOUT | Digital output which goes high at the end of a complete 4-channel data transfer. This can be connected to the CASCIN of the next device in a multichannel system to ensure proper control of the data transfer. |
| $\overline{\mathrm{RFS}}$ | Receive Frame Synchronization signal for the serial output data stream. This can be an input or output depending on the interface mode. |
| SDATA | Serial Data Input/Output Pin. |
| SCLK | Serial Clock Input/Output. The SCLK pin is configured as an input or output, depending on the state of the Mode pin. |
| $\overline{\text { DRDY }}$ | Data Ready Output. A falling edge indicates that a new word is available for transmission. It will return high when 4,32 -bit words have been transmitted. It also goes high for one clock cycle, when a new word is being loaded into the output register. Data should not be read during this period. |
| $\overline{\mathrm{TFS}}$ | Transmit Frame Sync input for programming the on-chip Control Register. |
| $\mathrm{D}_{\text {IN }} 1$ | Digital Data Input. This is contained in the digital data stream sent from the device. |
| $\mathrm{D}_{\text {OUT }} 1, \mathrm{D}_{\text {OUT }} 2$ | Digital Outputs. These two digital outputs can be programmed from the on-chip Control Register. They can be used to control calibration signals at the front end. |
| $\mathrm{V}_{\text {REF }}$ | Reference Input, Nominally 2.5 V . |
| AGND | Analog Ground. Ground reference for analog circuitry. |
| DGND | Digital Ground. Ground return for digital circuitry. |
| $\mathrm{A}_{\text {IN }} 1-\mathrm{A}_{\text {IN }} 4$ | Analog Input Pins. The analog input range is $\pm 2.5 \mathrm{~V}$. |

## TERMINOLOGY

## LINEARITY ERROR

This is the maximum deviation of any code from a straight line passing through the endpoints of the transfer function. The endpoints of the transfer function are zero scale (not to be confused with Bipolar Zero), a point 0.5 LSB below the first code transition ( $000 \ldots 000$ to $000 \ldots 001$ ) and full scale, a point 0.5 LSB above the last code transition ( $111 \ldots 110$ to $111 \ldots 111)$. The error is expressed as a percentage of full scale.

## DIFFERENTIAL LINEARITY ERROR/NO MISSED CODES

This is the difference between any code's actual width and the ideal ( 1 LSB ) width. Differential Linearity Error is expressed in LSBs. A differential linearity specification of $\pm 1$ LSB or less guarantees no missed codes to the full resolution of the device. The AD7716 has no missed codes guaranteed to 21 bits with a cutoff frequency of 146 Hz .

## GAIN ERROR

Gain Error is the deviation of the last code transition
( $111 \ldots 110$ to $111 \ldots$ ) from the ideal ( $\mathrm{V}_{\mathrm{REF}}-3 / 2 \mathrm{LSBs}$ ). It is expressed as a percentage of full scale.

## GAIN TC

This is the variation of gain error with temperature and is expressed in $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$.

## OFFSET ERROR

Offset Error is the deviation of the first code transition from the ideal $\left(-\mathrm{V}_{\mathrm{REF}}+0.5 \mathrm{LSB}\right)$. It is expressed as a percentage of full scale.

## OFFSET TC

This is the variation of offset error with temperature and is expressed in $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$.

## NOISE

This is the converter rms noise expressed in $\mu \mathrm{V}$. Because of the digital filtering in the sigma delta converter, the noise performance is a function of the programmed filter cutoff.

## SAMPLING RATE

This is the modulator sampling rate. For the AD7716, it is $\mathrm{f}_{\text {CLKIN }} / 14$.

## OUTPUT UPDATE RATE

This is the rate at which the digital filter updates the output shift register. It is a function of the master clock frequency and the programmed filter cutoff frequency.

## FILTER CUTOFF FREQUENCY

The digital filter of the AD7716 can be programmed, in binary steps, to 5 discrete cutoff frequencies, ranging from 584 Hz to 36.5 Hz (for a CLKIN frequency of 8 MHz ).

## SETTLING TIME

This is the settling time of the on-chip digital filter, to $0.0007 \%$ of FSR, in response to a full-scale step at the input of the ADC. It is proportional to the master clock frequency and the filter cutoff frequency.

## USABLE DYNAMIC RANGE

The usable dynamic range is the ratio of the rms full-scale reading (sine wave input) to the rms noise of the converter, expressed in dBs. It determines the level to which it is possible to resolve the input signal. For example, at a bandwidth of 146 Hz , the rms noise of the converter is $11 \mu \mathrm{~V}$. The full-scale rms is 1.77 volts. So, the usable dynamic range is 104 dB . Any signal below this level will be indistinguishable from noise unless extra post-filtering techniques are employed.

## TOTAL HARMONIC DISTORTION

Total harmonic distortion (THD) is the ratio of the rms sum of the harmonics to the fundamental. For the AD7716, it is defined as:

$$
T H D(d B)=20 \log \frac{\sqrt{V_{2}^{2}+V_{3}^{2}+V_{4}^{2}+V_{5}^{2}+V_{6}^{2}}}{V_{1}}
$$

where $V_{1}$ is the rms amplitude of the fundamental and $V_{2}, V_{3}$, $\mathrm{V}_{4}, \mathrm{~V}_{5}$ and $\mathrm{V}_{6}$ are the rms amplitudes of the second through sixth harmonics.

## ABSOLUTE GROUP DELAY

Absolute group delay is the rate of change of phase versus frequency, $\mathrm{d} \phi / \mathrm{df}$ and is expressed in seconds. For the AD7716, it is dependent on master clock frequency and filter cutoff frequency.

## DIFFERENTIAL GROUP DELAY

Differential group delay is the total variation in absolute group delay in the specified bandwidth. Since the digital filter in the AD7716 has perfectly linear phase, the differential group delay is almost zero. This is important in many signal processing applications where excessive differential group delay can cause phase distortion.

## AD7716

## GENERAL DESCRIPTION

The AD7716 is a 4 -channel 22 -bit $\mathrm{A} / \mathrm{D}$ converter with on-chip digital filtering, intended for the measurement of wide dynamic range, low frequency signals such as those representing ECG, EEG, chemical, physical or biological processes. It contains four sigma delta ADCs, a clock oscillator and a serial communications port.
Each of the analog input signals to the AD7716 is continuously sampled at a rate determined by the frequency of the master clock, CLKIN. Four sigma-delta modulators convert the sampled signals into digital pulse trains whose duty cycles contain the digital information. These are followed by low-pass filters to process the output of the modulators and update the output register at a maximum rate of 2.2 kHz . The output data can be read from the serial port at any rate up to this.

## THEORY OF OPERATION

The general block diagram of a delta-sigma ADC is shown in Figure 5. It contains the following elements.

1. Continuously Sampling Integrator
2. A Differential Amplifier or Subtracter
3. A 1-Bit A/D Converter (Comparator)

## 4. A 1-Bit DAC

## 5. A Digital Low-Pass Filter.

In operation, the sampled analog signal is fed to the subtracter, along with the output of the 1-bit DAC. The filtered difference signal is fed to the comparator, whose output samples the difference signal at a frequency many times that of the analog signal frequency (oversampling).
Oversampling is fundamental to the operation of delta-sigma ADCs. Using the quantization noise formula for an ADC:

$$
S N R=(6.02 \times \text { number of bits }+1.76) d B
$$

a 1-bit ADC or comparator yields an SNR of 7.78 dB .
When operating with a master clock of 8 MHz , the AD7716 samples the input signal at 570 kHz , which spreads the quantization noise from 0 kHz to 285 kHz . Since the specified analog input bandwidth of the AD7716 is only 584 Hz maximum (it can be programmed to be lower), the noise energy in this bandwidth would be only $1 / 488$ of the total quantization noise, assuming that the noise energy was spread evenly throughout the spectrum. This very high sampling with respect to the input bandwidth is known as oversampling, and the ratio of $488: 1$ is called the oversampling ratio. The noise is reduced still further by analog filtering in the modulator loop, which shapes the quantization noise spectrum to move most of the noise energy to frequencies above 584 Hz . The SNR performance in the 0 Hz to 584 Hz range is conditioned to the 99 dB level in this fashion (see Table I). As the programmed bandwidth is reduced, the oversampling ratio increases and the usable dynamic range also increases. Thus, for example, with a programmed bandwidth of 73 Hz , the oversampling ratio is $3904: 1$, and the usable dynamic range is 108 dB which corresponds to greater than 17-bit resolution.

The output of the comparator provides the digital input for the 1-bit DAC, so the system functions as a negative feedback loop which minimizes the difference signal. The digital data that represents the analog input voltage is in the duty cycle of the pulse train appearing at the output of the comparator. It can be retrieved as a parallel binary data word using a digital filter.


Figure 5. First Order Modulator
Sigma-delta ADCs are generally described by the order of the analog low-pass filter. A simple example of a first order sigmadelta ADC is shown in Figure 5. This contains only a firstorder low-pass filter or integrator.
The AD7716 uses a second-order sigma-delta modulator and a digital filter that provides a rolling average of the sampled output. After power-up or if there is a step change in the input voltage, there is a settling time before valid data is obtained.

## DIGITAL FILTERING

The AD7716's digital filter behaves like an analog filter, with a few minor differences.
First, since digital filtering occurs after the A-to-D conversion process, it can remove noise injected during the conversion process. Analog filtering cannot do this.
On the other hand, analog filtering can remove noise superimposed on the analog signal before it reaches the ADC. Digital filtering cannot do this and noise peaks riding on signals near full scale have the potential to saturate the analog modulator and digital filter, even though the average value of the signal is within limits. If noise signals cause the input signal to exceed the specified range, consideration should be given to analog input filtering, or to reducing the gain in the input channel to bring the combination of signal and noise spike within the specified input range.

## Filter Characteristics

The cutoff frequency of the digital filter is determined by bits FC2, FC1 and FC0 in the control register (See Table IV). The cutoff frequency of the filter is $\mathrm{f}_{\text {CLKIN }} /(3.81 \times 14 \times 256 \times 2 \mathrm{~N})$, where $N$ is the decimal equivalent of $\mathrm{FC} 2, \mathrm{FC} 1, \mathrm{FC} 0$. At the maximum clock frequency of 8 MHz , with all 0 s loaded to FC 2 , FC1, FC0, the cutoff frequency of the filter is 584 Hz and the data update rate is 2232 Hz .
Since the AD7716 contains low-pass filtering, there is a settling time associated with step function inputs, and data will be invalid after a step change until the settling time has elapsed. The
relationship between input bandwidth and settling is given in Table I. Because of this settling time, most sigma delta ADCs are unsuitable for high speed multiplexing, where channels are switched and converted sequentially at high rates, as switching between channels can cause a step change in the input. However, the AD7716 is a sigma-delta solution to multichannel applications, since it can process four channels simultaneously. In addition, it is easy to cascade several devices in order to increase the number of channels being processed.


Figure 6. Frequency Response of AD7716 Filter
Figure 6 shows the filter frequency response for a cutoff frequency of 73 Hz . This is a $(\sin \mathrm{x} / \mathrm{x})^{3}$ response (also called $\operatorname{sinc}{ }^{3}$ ) that provides greater than 100 dB rejection at the notch frequencies. The relationship between the programmed cutoff frequency and the first notch is constant $\left(\mathrm{f}_{\mathrm{NOTCH}}=3.81 \times\right.$ $\mathrm{f}_{\text {Cutoff }}$ ). The first notch frequency is also the output data rate. The settling time to a full-scale step input is four times the output data period. Programming a different cutoff frequency via FC0-FC2 does not alter the profile of the filter response, it simply changes the frequency of the notches.
In Figure 6, the first notch is at 278 Hz . This is also the output data rate. Settling time to a full-scale step input is 10.8 ms .

The digital filter can be defined by the following equations.

$$
\begin{aligned}
H(z) & =\left[\frac{1}{N} \times \frac{1-Z^{-N}}{1-Z^{-1}}\right]^{3} \\
|H(f)| & =\left|\frac{1}{N} \times \frac{\sin (N \times \pi f / f s)}{\sin (\pi f / f s)}\right|^{3} \\
\text { where } N & =\text { Oversampling Ratio } \\
f s & =\text { Modulator Sampling Rate }
\end{aligned}
$$

## Post Filtering

In the AD7716, the on-chip modulator provides the digital filter with samples at a rate of 570 kHz . The filter decimates these samples to provide data at an output rate which corresponds to the programmed first notch frequency of the filter.
If the user wants to reduce the output noise from the device for bandwidths less than 36.5 Hz , then it is possible to employ extra filtering after the AD7716. This extra digital filtering is called post filtering. If a straight averaging filter is used, for example, a reduction in bandwidth by a factor of 2 results in $\sqrt{2}$ reduction in the rms noise. This additional filtering will also result in a longer settling time.

## Antialias Considerations

The digital filter does not provide any rejection at integer multiples of the modulator sampling frequency ( $\mathrm{n} \times 570 \mathrm{kHz}$, where $\mathrm{n}=1,2,3, \ldots$ ). This means that there are frequency bands, $\pm \mathrm{f}_{3 \mathrm{~dB}}$ wide ( $\mathrm{f}_{3 \mathrm{~dB}}$ is the cutoff frequency selected by FC0 to FC2) where noise passes unattenuated to the output. However, due to the AD7716's high oversampling ratio, these bands occupy only a small fraction of the spectrum and most broadband noise is filtered.
In spectral analysis applications, it is important to note that attenuation at half the output update rate is 16 dB . Extra frontend filtering or post filtering may be required to keep aliases in this frequency band at an acceptable level.

## USING THE AD7716 SYSTEM DESIGN CONSIDERATIONS

The AD7716 operates differently from successive approximation ADCs or other integrating ADCs. Since it samples the signal continuously, like a tracking ADC, there is no need for a start convert command. The output register is updated at a rate dependent on the programmed cutoff frequency, and the output can be read at any time.

## Input Signal Conditioning

The input range for the AD 7716 is $\pm \mathrm{V}_{\mathrm{REF}}$, where $\mathrm{V}_{\mathrm{REF}}=2.5 \mathrm{~V}$ $\pm 10 \%$. Other input ranges can be accommodated by input signal conditioning. This may take the form of gain to increase a smaller signal range, or passive attenuation to reduce a larger input voltage range.

## AD7716

## Source Resistance

If passive attenuators are used in front of the AD7716, care must be taken to ensure that the source impedance is sufficiently low. The dc input resistance for the AD7716 is greater than $1 \mathrm{G} \Omega$. In parallel with this there is a small sampling capacitor. The dynamic load presented by this varies with the clock frequency. The modulator sampling rate determines the amount of time available for the sampling capacitor to be charged. Any extra external impedances result in a longer overall charge time resulting in extra gain errors on the analog input. The AD7716 has a quite large gain error ( $1 \%$ FSR) due to the fact that there is no on-chip calibration. Thus, even an extra $10 \mathrm{k} \Omega$ source resistance and 50 pF source capacitance will have no significant effect on this.
Active signal conditioning circuits such as op amps generally do not suffer from problems of high source impedance. Their open-loop output resistance is normally only tens of ohms and, in any case, most modern general purpose op amps have sufficiently fast closed-loop settling time for this not to be a problem.

## Accuracy

Sigma-delta ADCs, like VFCs and other integrating ADCs, do not contain any source of nonmonotonicity and inherently offer no missing codes performance.

The AD7716 achieves excellent linearity by the use of high quality, on-chip silicon dioxide capacitors, which have a very low capacitance/voltage coefficient.

## Drift Considerations

The AD7716 uses autozeroing techniques to minimize input offset drift. Charge injection in the analog switches and leakage currents at the sampling node are the primary sources of offset voltage drift in the converter. Figure 7 indicates the typical offset due to temperature changes. Drift is relatively flat up to $85^{\circ} \mathrm{C}$. Above this temperature, leakage current becomes the main source of offset drift. Since leakage current doubles approximately every $10^{\circ} \mathrm{C}$, the offset drifts accordingly. The value of the voltage on the sample capacitor is updated at a rate determined by the master clock, therefore the amount of offset drift which occurs will be proportional to the elapsed time between samples.
Gain drift within the converter depends mainly upon the temperature tracking of the internal capacitors. It is not affected by leakage currents.


Figure 7. Typical Offset Drift

## Voltage Reference

The voltage applied to the $\mathrm{V}_{\text {REF }}$ pin defines the analog input range. The specified reference voltage is $2.5 \mathrm{~V} \pm 10 \%$.
The reference input presents exactly the same dynamic load as the analog input, but in the case of the reference input, source resistance and long settling time introduce gain errors rather than offset errors. Most precision references however have sufficiently low output impedance and wide enough bandwidth to settle to the required accuracy in the time allowed by the AD7716.

The reference should be chosen to have minimal noise in the programmed passband. Recommended references are the AD780 or the REF43 from Analog Devices. These low noise references have typical noise spectral densities of $100 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ at 600 Hz . This corresponds to an rms noise of $2.5 \mu \mathrm{~V}$ in this band and is more than adequate for the AD7716.

## Clock Generation

The device operates from a master clock which must be provided either from a crystal source or an external clock source. If a crystal is used, it must be connected across the CLKIN and CLKOUT pins. Typical loading capacitors of 15 pF are required on CLKIN, CLKOUT. The crystal manufacturers data should be consulted for more information. An external clock can also be used to drive the CLKIN input directly with a CMOS compatible clock. In this case, CLKOUT is left unconnected. The nominal clock frequency for the device is 8 MHz .

## CONTROL REGISTER DESCRIPTION

The 16-bit control register is programmed in two 8-bit bytes; the low byte is programmed first and the high byte second. The loading format is LSB first (DB0 for the Least Significant Byte; DB8 for the Most Significant Byte). Three control lines are used: TFS, SCLK and SDATA. On initial application of power to the AD7716, the control register will come up in an undetermined state. Programming the control register requires an SCLK input, a TFS input and an SDATA input. The MODE pin on the device determines whether it is in the master interface mode or the slave interface mode. In either mode, a falling edge on TFS causes the part to relinquish control of the SDATA and SCLK lines. When TFS goes low, data on the SDATA line is clocked into the control register on each succeeding falling edge of SCLK. When 8 bits have been clocked in, the transfer automatically stops. Only when another negative going edge is detected on $\overline{\mathrm{TFS}}$ will new information be written into the control register. The control register programming model is shown in Table II. Bits DB8 and DB0 allow the control register to identify whether the MS Byte or the LS Byte has been programmed. Only when DB8 is a 1 and DB0 is a 0 will the register recognize that a complete valid word has been programmed.

Control register bit, DB15 (A3), acts as an extra address bit which must always be set to 1 to enable programming of the AD7716. If it is set to 0 , then the programmed word is ignored. This allows the user to bypass the AD7716 control register and use the serial stream from the DSP or microcomputer to program other serial peripheral devices.
When a valid word has been received, the device interrogates the M0 bit. If this is 0 , then the digital filter cutoff frequencies are programmed to the appropriate value if the device address pins correspond to the $\mathrm{A} 2, \mathrm{~A} 1, \mathrm{~A} 0$ bits in the control register. If the device address pins do not correspond to the A2, A1, A0 bits then the $\mathrm{FC} 2, \mathrm{FC} 1, \mathrm{FC} 0$ bits are ignored. If M 0 is 1 , then the digital filter cutoff frequencies are programmed to the FC2, $\mathrm{FC} 1, \mathrm{FC} 0$ value irrespective of the address bits. In a multichannel system this allows the user to either program all AD7716s to have the same cutoff frequency or else to give each device a separate cutoff frequency.
Control register bits FC2, FC1, FC0 program the digital filter cutoff frequency, see Table VI.
Control register bits D2, D1 control the digital output pins D2 and D1. These are programmed in the same way as $\mathrm{FC} 2, \mathrm{FC} 1$, FC0.

Table II. Control Register Programming Model

| Most Significant Byte |  |  |  |  | Least Significant Byte |  |  |  |  |  |  |  |  |  |  |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| DB15 | DB14 | DB13 | DB12 | DB11 | DB10 | DB9 | DB8 | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |
| A3 | A2 | A1 | A0 | M0 | FC2 | FC1 | 1 | FC0 | DOUT2 | DOUT1 | X | X | X | X | 0 |

Table III. M0 Truth Table

| M0 | Programming Mode |
| :--- | :--- |
| 0 | A2, A1, A0 determine which device is addressed and <br> programmed with cutoff frequency and digital output. |
| 1 | A2, A1, A0 ignored. All devices are addressed and <br> programmed with common cutoff frequency and digital <br> output. |

Table IV. Cutoff Frequency Truth Table

| FC2 | FC1 | FC0 | Cutoff Frequency (Hz) |
| :--- | :--- | :--- | :--- |
| 0 | 0 | 0 | 584 |
| 0 | 0 | 1 | 292 |
| 0 | 1 | 0 | 146 |
| 0 | 1 | 1 | 73 |
| 1 | 0 | 0 | 36.6 |

## AD7716

## RESET

The AD7716 has a hardware reset which can be used to synchronize many devices. When the RESET pin goes low after being high for at least four CLKIN cycles, the modulator sampling points and digital filter starting points are all synchronized. This synchronizes all devices which receive the RESET pulse and gives simultaneous sampling of all channels. It does not affect the control register but restarts the interface. Also, it is necessary to wait the requisite settling time after applying Reset to get valid data from the device.

## CASCADING DEVICES

The AD7716 provides a facility for connecting multiple devices in series. The CASCIN and CASCOUT pins allow this. Connecting CASCOUT to CASCIN of the succeeding device means that the SDATA output of the second device will be disabled until the output register of the first device is empty.
In the case of the first device in the system, it is possible to drive CASCIN from CASCOUT of the last device or, alternatively, invert $\overline{\mathrm{DRDY}}$ to drive it. If CASCIN is driven by CASCOUT, then a reset must be applied after every write to the control register. This also applies in single device systems that use CASCOUT to drive CASCIN

## DATA OUTPUT INTERFACE MODES

When the control register has been programmed, the device begins conversion. There is an initial delay to allow the digital filters to settle. As already stated, these filters are Sinc ${ }^{3}$, and so the filter output update rate is directly related to the programmed cutoff frequency. The ratio between these is 3.81 . So, for a filter cutoff frequency of 584 Hz , the output update is 2.22 kHz . The falling edge of the $\overline{\mathrm{DRDY}}$ output indicates that the output shift register has been updated. There are two interface modes. One is the master mode, where the AD7716 is the master in the system and the processor to which it is communicating is the slave. The other mode is the slave mode, where the AD7716 is the slave and the processor is the system master. In both of these modes the data output stream contains $4 \times 32$ bits, corresponding to the four input channels. The output data format is given in Table V. The conversion result DB21-DB0 occupies location DB31-DB10 of the output register. DB21 is the MSB and is transmitted first as shown in the timing diagrams. The channel address is given by CA0 and CA1 which occupy DB9 and DB8 of the output register. The channel address format is given in Table VI.

## Master Mode Interface

The device may be placed in the Master Mode by tying the MODE pin low. In this mode, data is clocked out of the AD7716 by an internally generated serial clock and frame synchronization pulse. Two signals initiate the transfer. These are the input CASCIN and the internally generated $\overline{\mathrm{DRDY}}$ signal. When a high level is detected on CASCIN, the device checks the state of DRDY. Note, that on initial power-up or after a reset has been applied, the CASCIN input is not necessary on device 000 for the first data transfer but is required thereafter. If $\overline{\mathrm{DRDY}}$ is low, then the 3-state output, $\overline{\mathrm{RFS}}$ goes high on the next rising edge of CLKIN and stays high for one CLKIN cycle before going low again. The 3-state SCLK output is also activated on the same rising edge. As $\overline{\text { RFS }}$ goes low, DB31 is clocked out on the rising edge of SCLK and is valid on the falling edge of SCLK. Data is transmitted in 8 -bit bytes. For each $\mathrm{A}_{\mathrm{IN}}$, there are 4,8 -bit bytes and $4 \overline{\mathrm{RFS}}$ pulses. When DB0 of $\mathrm{A}_{\text {IN }} 4$ has been clocked out, SCLK goes back into 3-state and the CASCOUT output goes high for one master clock cycle. DRDY also goes high at this point. Successive devices can be networked together by tying the CASCOUT of one device to the CASCIN on the next one.
Note that on device 0 (A2, A1, A0 tied low), the CASCIN input should be driven by the inverse of the DRDY output. This is shown in the interface diagram of Figure 8.
The Master Mode interface is very suitable for loading data into a serial-to-parallel shift register or for DSPs which can accept a continuous stream of 8-bit bytes.

## Slave Mode Interface

The device may be placed in the slave interface mode by tying the MODE pin high. In this mode, the master processor controls the transfer of data from the signal processing block. It starts the transfer by sending a frame synchronizations pulse and serial clock to the AD7716. This could be in response to an interrupt generated by the $\overline{\mathrm{DRDY}}$ output on the AD7716. If the device has detected a high level on CASCIN or is device 000 on its first transfer, it starts to send out data on the next rising edge of SCLK. This data is then valid on the falling edge of SCLK. When all the data bits have been clocked out, the CASCOUT pin goes high for one CLKIN cycle and $\overline{\mathrm{DRDY}}$ also goes high. The slave mode interface is suited to both microcomputers like the 8051 and 68 HC 11 and also DSPs like the TMS320C25, ADSP-2101 family and the DSP56000 family.

Table V. Output Data Word Format

| DB31 ... DB10 | DB9 $\quad$ DB8 | DB7 $\quad$ DB6 DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| DB21 ... DB0 | CA0 CA1 | A0 A1 A2 | D IN 1 | OVFL | X | X | X |
| Conversion Result | Channel Address | Device Address | Pace Detect | Overflow | Indeterminate |  |  |

Table VI. Channel Address Format

| Channel | CA1 (DB8) | CA0 (DB9) |
| :--- | :--- | :--- |
| $\mathrm{A}_{\text {IN }} 1$ | 0 | 0 |
| $\mathrm{~A}_{\text {IN }} 2$ | 0 | 1 |
| $\mathrm{~A}_{\text {IN }} 3$ | 1 | 0 |
| $\mathrm{~A}_{\text {IN }} 4$ | 1 | 1 |

## MICROPROCESSOR INTERFACING

## Interfacing the AD7716 to the ADSP-2100 Family

The ADSP-2100 family of microcomputers from Analog Devices are high speed, high performance digital signal processors. Many members of the family have serial ports (known as SPORTs) which are compatible with the AD7716. These include the ADSP-2101, ADSP-2105, ADSP-2111 and ADSP2115. Full details of these are available in the $A D S P-2100$ Family User's Manual available from Analog Devices.
Figure 8 shows the hardware interface between two AD7716s and SPORT 0 of the ADSP-2101 DSP. This yields a very efficient 8 -channel data acquisition system. The AD7716 is set up for slave interface mode by tying the MODE pin high. This means that the ADSP-2101 is the master in the system and supplies the necessary frame synchronization and SCLK Signals to the AD7716s when writing to and reading from the device.
On power up, the user should write to the AD7716 control register in order to set the filter cutoff frequencies. The appropriate SPORT 0 Control Register ( $0 \times 3 \mathrm{FF} 6$ ) setting is " 7 EC 7 ." This sets the transmit section for alternate inverted framing with a word length of 8 bits. Two 8 -bit words should then be written to each AD7716 to program the filter cutoff frequencies. The control register programming model is given in Table II. Note that the LSB (DB0) must be loaded first as in the timing diagram of Figure 2.
When the write operation is complete, a reset pulse should be applied to both devices. This ensures that the sampling and interface timing of the device are synchronized. The reset can be under DSP control, in which case a flag output could be used.
After reset, the processor should jump to the read routine. For this read routine, there are several registers that need to be set.

The SPORT0 Control Register setting is "7FCF." This sets the receive section for internal SCLK, continuous receive with alternate inverted framing.
The SPORT0 SCLKDIV Register ( $0 \times 3$ FF5) determines the SCLK frequency from the ADSP-2101. With " 0000 " loaded, the SCLK output is at its maximum ( $1 / 2$ the master clock of 12.5 MHz ).

In normal operation, a SPORT generates an interrupt when it has received a data word. Autobuffering provides a mechanism for receiving or transmitting an entire block of serial data before an interrupt is generated. Service routines can operate on the entire block of data, rather than on a single word, reducing overhead significantly. This is ideal for use with a device like the AD7716 where there is a requirement to read many bits of data ( 256 in this case) for each sampling instant. The SPORT0 Autobuffer Control Register ( $0 \times 3 \mathrm{FF} 3$ ) is loaded with " 0001 " to enable the Receive Autobuffering.
The SPORT0 RFSDIV Register ( $0 \times 3 \mathrm{FF} 4$ ) should be set to the minimum value of " 000 F ." Finally the IRQ2 interrupt should be enabled.
The DSP will now wait for an interrupt from the AD7716. This interrupt is generated by the AD7716 $\overline{\mathrm{DRDY}}$ line going low. If the interrupt service routine is set for autobuffered mode with a length of 16 (16-bit) words, then the DSP will read in the 256 bits from the two AD7716s in one continuous stream and then stop. The data from the two devices will be contained in the designated data memory area and the DSP can now go and operate on this as is necessary. Note that, because of the ADSP2101 framing, a one-bit shift left will be necessary on the data in memory. For 16 data words, this will require 22 instruction cycles.


Figure 8. 8-Channel Data Acquisition System Using the ADSP-2101 Digital Signal Processor

## FEATURES

AD7776: Single Channel
AD7777: 4-Channel
AD7778: 8-Channel
Fast 10-Bit ADC: 2.5 us Worst Case
+5 V Only
Half-Scale Conversion Option
Fast Interface Port
Power-Down Mode

## APPLICATIONS

HDD Servos
Instrumentation

## GENERAL DESCRIPTION

The AD7776, AD7777 and AD7778 are a family of high speed, multichannel, 10-bit ADCs primarily intended for use in $\mathrm{R} / \mathrm{W}$ head positioning servos found in high density hard disk drives. They have unique input signal conditioning features which make them ideal for use in such single supply applications.
By setting a bit in a control register within both the fourchannel version, AD7777, and eight-channel version, AD7778, the input channels can either be independently sampled or any two channels of choice can be simultaneously sampled. For all versions the specified input signal range is of the form $\mathrm{V}_{\text {BIAS }} \pm \mathrm{V}_{\text {SwING }}$. However, if the RTN pin is biased at, say, 2 V then the analog input signal range becomes 0 V to +2 V for all input channels. This is dealt with in more detail under the section Changing the Analog Input Voltage Range. The voltage $\mathrm{V}_{\text {BIAS }}$ is the offset of the ADC's midpoint code from ground and is supplied either by an onboard reference available to the user (REFOUT) or by an external voltage reference applied to REFIN. The full-scale range (FSR) of the ADC is equal to $2 \mathrm{~V}_{\text {SwING }}$ where $\mathrm{V}_{\text {SwING }}$ is nominally equal to REFIN/2. Additionally, when placed in the half-scale conversion mode, the value of REFIN is converted. This allows the channel offset(s) to be measured.
Control register loading and ADC register reading, channel select and conversion start are under the control of the $\mu \mathrm{P}$. The twos complemented coded ADCs are easily interfaced to a standard 16 -bit MPU bus via their 10 -bit data port and standard microprocessor control lines.
They are fabricated in linear compatible CMOS ( $\mathrm{LC}^{2} \mathrm{CMOS}$ ), an advanced, mixed technology process that combines precision bipolar circuits with low power CMOS logic. The AD7776 is available in a 24 -pin SOIC package; the AD7777 is available in both 28 -pin DIP and 28 -pin SOIC packages; the AD7778 is available in a 44-pin PQFP package.
*Protected by U.S. Patent No. 4,990,916.

FUNCTIONAL BLOCK DIAGRAMS


This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

AD7776/AD7717/AD7778
RTN $=0 \mathrm{~V} ; \mathrm{C}_{\text {REFIN }}=10 \mathrm{nF}$; all specifications $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ unless otherwise noted.)

| Parameter | A Versions ${ }^{1}$ | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: |
| DC ACCURACY <br> Resolution ${ }^{2}$ <br> Relative Accuracy <br> Differential Nonlinearity <br> Bias Offset Error <br> Bias Offset Error Match <br> Plus or Minus Full-Scale Error <br> Plus or Minus Full-Scale Error Match | $\begin{aligned} & 10 \\ & \pm 1 \\ & \pm 1 \\ & \pm 12 \\ & 10 \\ & \pm 12 \\ & 10 \end{aligned}$ | Bits <br> LSB max <br> LSB max <br> LSB max <br> LSB max <br> LSB max <br> LSB max | See Terminology <br> No Missing Codes; See Terminology <br> See Terminology <br> Between Channels, AD7777/AD7778 Only; See Terminology <br> See Terminology <br> Between Channels, AD7777/AD7778 Only; See Terminology |
| ANALOG INPUTS <br> Input Voltage Range <br> All Inputs Input Current | $\begin{aligned} & V_{\text {BIAS }} \pm V_{\text {SWING }} \\ & +200 \end{aligned}$ | $\begin{aligned} & V \min / V \max \\ & \mu \mathrm{~A} \max \end{aligned}$ | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {BIAS }} \pm \mathrm{V}_{\text {SWING }} ;$ Any Channel |
| REFERENCE INPUT REFIN REFIN Input Current | $\begin{aligned} & 1.9 / 2.1 \\ & +200 \end{aligned}$ | $\begin{aligned} & V \min / V \max \\ & \mu \mathrm{~A} \max \end{aligned}$ | For Specified Performance |
| REFERENCE OUTPUT <br> REFOUT <br> DC Output Impedance Reference Load Change <br> Short Circuit Current ${ }^{3}$ | $\begin{aligned} & 1.9 / 2.1 \\ & 5 \\ & \pm 2 \\ & \pm 5 \\ & \\ & 20 \end{aligned}$ | $\mathrm{V} \min / \mathrm{V}$ max $\Omega$ typ mV max $m V$ max <br> mA max | Nominal REFOUT $=2.0 \mathrm{~V}$ <br> For Reference Load Current Change of 0 to $\pm 500 \mu \mathrm{~A}$ For Reference Load Current Change of 0 to $\pm 1 \mathrm{~mA}$ Reference Load Should Not Change During Conversion See Terminology |
| LOGIC OUTPUTS <br> DB0-DB9, $\overline{\text { BUSY/ }} / \overline{I N T}$ <br> $\mathrm{V}_{\mathrm{OL}}$, Output Low Voltage <br> $\mathrm{V}_{\mathrm{OH}}$, Output High Voltage <br> Floating State Leakage Current <br> Floating State Capacitance ${ }^{3}$ <br> ADC Output Coding | $\begin{aligned} & 0.4 \\ & 4.0 \\ & \pm 10 \\ & 10 \\ & \text { Twos Complement } \end{aligned}$ | $V_{\text {max }}$ V min $\mu \mathrm{A}$ max pF max | $\begin{aligned} & \mathrm{I}_{\text {SINK }}=1.6 \mathrm{~mA} \\ & \mathrm{I}_{\text {SOURCE }}=200 \mu \mathrm{~A} \end{aligned}$ |
| LOGIC INPUTS <br> DB0-DB9, $\overline{\mathrm{CS}}, \overline{\mathrm{WR}}, \overline{\mathrm{RD}}, \mathrm{CLKIN}$ <br> Input Low Voltage, $\mathrm{V}_{\text {INL }}$ <br> Input High Voltage, $\mathrm{V}_{\text {INH }}$ <br> Input Leakage Current <br> Input Capacitance ${ }^{3}$ | $\begin{aligned} & 0.8 \\ & 2.4 \\ & 10 \\ & 10 \end{aligned}$ | V max <br> V min <br> $\mu \mathrm{A}$ max <br> pF max |  |
| CONVERSION TIMING <br> Acquisition Time <br> Single Conversion <br> Double Conversion <br> $\mathrm{t}_{\text {CLKIN }}$ <br> $t_{\text {clein }}$ High <br> $t_{\text {CLKIN }}$ Low | $\begin{aligned} & 4.5 \mathrm{t}_{\mathrm{CLKIN}} \\ & 5.5 \mathrm{t}_{\mathrm{CLKIN}}+70 \\ & 14 \mathrm{t}_{\mathrm{CLKIN}} \\ & 28 \mathrm{t}_{\mathrm{CLKIN}} \\ & 125 / 500 \\ & 50 \\ & 40 \end{aligned}$ | ns min <br> ns max <br> ns max <br> ns max <br> ns $\min / n s \max$ <br> ns min <br> ns min | See Terminology <br> Period of Input Clock CLKIN Minimum High Time for CLKIN Minimum Low Time for CLKIN |
| POWER REQUIREMENTS <br> $\mathrm{V}_{\mathrm{CC}}$ Range <br> $\mathrm{I}_{\mathrm{CC}}$, Normal Mode <br> $\mathrm{I}_{\mathrm{CC}}$, Power-Down Mode <br> Power-Up Time to Operational Specifications | $\begin{aligned} & +4.75 /+5.25 \\ & 15 \\ & 1.5 \\ & \\ & 500 \end{aligned}$ | $\mathrm{V} \min / \mathrm{V}$ max <br> $m A \max$ <br> mA max <br> $\mu s$ max | For Specified Performance $\overline{\mathrm{CS}}=\overline{\mathrm{RD}}=+5 \mathrm{~V}, \mathrm{CR} 8=0$ <br> CR8 $=1$. All Linear Circuitry OFF <br> From Power-Down Mode |
| DYNAMIC PERFORMANCE <br> Signal to Noise and Distortion $\mathrm{S} /(\mathrm{N}+\mathrm{D})$ Ratio <br> Total Harmonic Distortion (THD) Intermodulation Distortion (IMD) <br> Channel-to-Channel Isolation | $\begin{aligned} & -57 \\ & -60 \\ & -75 \\ & -90 \end{aligned}$ | dB min <br> dB min <br> dB typ <br> dB typ | See Terminology <br> $\mathrm{V}_{\text {IN }}=99.88 \mathrm{kHz}$ Full-Scale Sine Wave with $\mathrm{f}_{\text {SAMPLING }}=380.95 \mathrm{kHz}$ <br> $\mathrm{V}_{\text {IN }}=99.88 \mathrm{kHz}$ Full-Scale Sine Wave with $\mathrm{f}_{\text {SAMPLING }}=380.95 \mathrm{kHz}$ <br> $\mathrm{fa}=103.2 \mathrm{kHz}, \mathrm{fb}=96.5 \mathrm{kHz}$ with $\mathrm{f}_{\text {SAMPLING }}=380.95 \mathrm{kHz}$. Both <br> Signals Are Sine Waves at Half-Scale Amplitude <br> $\mathrm{V}_{\mathrm{IN}}=100 \mathrm{kHz}$ Full-Scale Sine Wave with $\mathrm{f}_{\text {SAMPLING }}=380.95 \mathrm{kHz}$ |

[^72]TIMING SPECIFICATIONS ${ }^{1,2} \underset{\text { noted. })}{\left(\mathrm{V}_{\mathrm{cc}}=\right.}+5 \mathrm{~V} \pm 5 \%$; AGND $=$ DGND $=0 \mathrm{~V}$; all specifications $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {Max }}$ unless otherwise


## NOTES

${ }^{1}$ See Figures 1 to 3.
${ }^{2}$ Timing specifications in bold print are $100 \%$ production tested. All other times are guaranteed by design, not production tested. All input signals are specified with $\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of 5 V$)$ and timed from a voltage level of 1.6 V .
${ }^{3} \mathrm{t}_{4}$ is measured with the load circuit of Figure 4 and defined as the time required for an output to cross 0.8 V or 2.4 V .
${ }^{4} \mathrm{t}_{5}$ is derived from the measured time taken by the data outputs to change 0.5 V when loaded with the circuit of Figure 4 . The measured time is then extrapolated back to remove the effects of charging or discharging the 100 pF capacitor. This means that the time $\mathrm{t}_{5}$ quoted above is the true bus relinquish time of the device and, as such, is independent of the external bus loading capacitance.
Specifications subject to change without notice.


Figure 1. Read Cycle Timing


Figure 2. Write Cycle Timing


Figure 3. BUSY/INT Timing


Figure 4. Load Circuit for Bus Timing Characteristics

## ABSOLUTE MAXIMUM RATINGS ${ }^{\star}$

( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)
$\mathrm{V}_{\mathrm{CC}}$ to AGND or DGND . . . . . . . . . . . . . $-0.3 \mathrm{~V},+7 \mathrm{~V}$
AGND, RTN to DGND . . . . . . . . . . $-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}+0.3 \mathrm{~V}$
$\overline{\mathrm{CS}}, \overline{\mathrm{RD}}, \overline{\mathrm{WR}}, \mathrm{CLKIN}, \mathrm{DB} 0-\mathrm{DB} 9$, BUSY/INT to DGND . . . . . . . . . . $-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}+0.3 \mathrm{~V}$
Analog Input Voltage to AGND . . . . $-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{Cc}}+0.3 \mathrm{~V}$
REFOUT to AGND . . . . . . . . . . . $-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}+0.3 \mathrm{~V}$
REFIN to AGND . . . . . . . . . . . . . . . $-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}+0.3 \mathrm{~V}$
Operating Temperature Range
All Versions . . . . . . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Junction Temperature . . . . . . . . . . . . . . . . . . . . . . $+150^{\circ} \mathrm{C}$
DIP Package, Power Dissipation . . . . . . . . . . . . . . 875 mW
$\theta_{\mathrm{JA}}$ Thermal Impedance . . . . . . . . . . . . . . . . . . . 75 ${ }^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature, Soldering ( 10 sec ) . . . . . . . . . $+260^{\circ} \mathrm{C}$

SOIC Packages, Power Dissipation . . . . . . . . . . . . . 875 mW
$\theta_{\mathrm{JA}}$ Thermal Impedance . . . . . . . . . . . . . . . . . . $75^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature, Soldering
Vapor Phase ( 60 sec ) . . . . . . . . . . . . . . . . . . . . $+215^{\circ} \mathrm{C}$
Infrared (15 sec) . . . . . . . . . . . . . . . . . . . . . . $+220^{\circ} \mathrm{C}$
PQFP Package, Power Dissipation . . . . . . . . . . . . . 500 mW
$\theta_{\mathrm{JA}}$ Thermal Impedance . . . . . . . . . . . . . . . . . . . $95^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature, Soldering
Vapor Phase ( 60 sec ) . . . . . . . . . . . . . . . . . . . $+215^{\circ} \mathrm{C}$
Infrared (15 sec) . . . . . . . . . . . . . . . . . . . . . . $+220^{\circ} \mathrm{C}$
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V , which readily accumulate on the human body and on test equipment, can discharge without detection. Although these devices feature proprietary ESD protection circuitry, permanent damage may still occur on these devices if they are subjected to high energy electrostatic discharges. Therefore, proper precautions are recommended to avoid any performance degradation or loss of functionality.


## PIN CONFIGURATIONS



28-Pin DIP \& SOIC


44-Pin PQFP


ORDERING GUIDE

| Model | Temperature <br> Range | No. of <br> Channels | Package <br> Option $^{1,2}$ |
| :--- | :--- | :---: | :---: |
| AD7776AR ${ }^{3}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 1 | $\mathrm{R}-24$ |
| AD7777AN $^{\text {AD7777AR }}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 4 | $\mathrm{~N}-28$ |
| AD $^{\circ}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 4 | R-28 |
| AD7778AS $^{3}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8 | $\mathrm{~S}-44$ |

## NOTES

${ }^{1} \mathrm{R}=$ SOIC, $\mathrm{N}=$ Plastic DIP, $\mathrm{S}=\mathrm{PQFP}$.
${ }^{2}$ For outline information see Package Information section.
${ }^{3}$ Analog Devices reserves the right to ship devices branded with a J in place of the A, e.g., AD7776JR instead of AD7776AR. Temperature range remains $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.

| Mnemonic | Description |
| :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | +5 V Power Supply. |
| AGND | Analog Ground. |
| DGND | Digital Ground. Ground reference for digital circuitry. |
| DB0-DB9 | Input/Output Data Bus. This is a bidirectional data port from which ADC output data may be read and to which control register data may be written. |
| $\overline{\text { BUSY}} / \overline{\mathrm{INT}}$ | Busy/Interrupt Output. Active low logic output indicating A/D converter status. This logic output has two modes of operation depending on whether location CR9 of the control register has been set low or high: <br> If CR9 is set low, then the $\overline{\text { BUSY }} / \overline{\mathrm{INT}}$ output will behave as a $\overline{\mathrm{BUSY}}$ signal. The $\overline{\mathrm{BUSY}}$ signal will go low and stay low for the duration of a single conversion, or if simultaneous sampling has been selected, $\bar{B} U S Y$ will stay low for the duration of both conversions. <br> If CR9 is set high, then the $\overline{\mathrm{BUSY}} / \overline{\mathrm{INT}}$ output behaves as an INTERRUPT signal. The $\overline{\mathrm{INT}}$ signal will go low and remain low after either a single conversion is completed or after a double conversion is completed if simultaneous sampling has been selected. With CR9 high, the falling edge of $\overline{\mathrm{WR}}$ or $\overline{\mathrm{RD}}$ resets the $\overline{\mathrm{INT}}$ line high. |
| $\overline{\mathrm{CS}}$ | Chip Select Input. The device is selected when this input is low. |
| WR | Write Input (Active Low). It is used in conjunction with $\overline{\mathrm{CS}}$ to write data to the control register. Data is latched to the registers on the rising edge of $\overline{\mathrm{WR}}$. Following the rising edge of $\overline{\mathrm{WR}}$, the analog input is acquired and a conversion is started. |
| $\overline{\mathrm{RD}}$ | Read Input (Active Low). It is used in conjunction with $\overline{\mathrm{CS}}$ to enable the data outputs from the ADC registers. |
| $\mathrm{A}_{\text {IN }} 1-8$ | Analog Inputs 1-8. The analog input range is $V_{\text {BIAS }} \pm \mathrm{V}_{\text {SWING }}$ where $\mathrm{V}_{\text {BIAS }}$ and $\mathrm{V}_{\text {SWING }}$ are defined by the reference voltage applied to REFIN. Input resistance between any of the analog input pins and AGND is $10 \mathrm{k} \Omega$ or greater. |
| REFIN | Voltage Reference Input. The AD7776/AD7777/AD7778 are specified over a voltage reference range of 1.9 V to 2.1 V with a nominal value of 2.0 V . This REFIN voltage provides the $\mathrm{V}_{\text {BIAS }}$ and $\mathrm{V}_{\text {SwING }}$ levels for the input channel(s). $\mathrm{V}_{\text {BIAS }}$ is equal to REFIN and $\mathrm{V}_{\text {SWING }}$ is nominally equal to REFIN/2. Input resistance between this REFIN pin and AGND is $10 \mathrm{k} \Omega$ or greater. |
| REFOUT | Voltage Reference Output. The internal voltage reference, which is nominally 2.0 V and can be used to provide the bias voltage ( $\mathrm{V}_{\text {BIAS }}$ ) for the input channel(s), is provided at this pin. |
| $\mathrm{C}_{\text {REFIN }}$ | Reference Decoupling Capacitor. A 10 nF capacitor must be connected from this pin to AGND to ensure correct operation of the high speed ADC. |
| RTN | Signal Return Path for the input channel(s). Normally RTN is connected to AGND at the package. |

## CIRCUIT DESCRIPTION

## ADC Transfer Function

For all versions, an input signal of the form $V_{\text {BIAS }} \pm V_{\text {SWING }}$ is expected. This $\mathrm{V}_{\text {bias }}$ signal level operates as a psuedo ground to which all input signals must be referred. The $\mathrm{V}_{\text {bias }}$ level is determined by the voltage applied to the REFIN pin. This can be driven by an external voltage source; or, alternatively, the onboard 2 V reference, available at REFOUT, can be used. The magnitude of the input signal swing is equal to $\mathrm{V}_{\mathrm{BIAS}} / 2$ (or REFIN/2) and is set internally. With a REFIN of 2 V , the ana$\log$ input signal level varies from 1 V up to 3 V i.e., $2 \pm 1 \mathrm{~V}$. Figure 5 shows the transfer function of the ADC and its relationship to $\mathrm{V}_{\text {BIAS }}$ and $\mathrm{V}_{\text {SWING }}$. The half-scale twos complement code of the ADC, 000 Hex ( 0000000000 Binary), occurs at an input voltage equal to $\mathrm{V}_{\text {bias }}$. The input full-scale range of the ADC is equal to $2 \mathrm{~V}_{\text {SwING }}$, so that the Plus Full-Scale transition ( 1 FE to 1 FF ) occurs at a voltage equal to $\mathrm{V}_{\text {BIAs }}+\mathrm{V}_{\text {Swing }}-$ 1.5 LSBs and the minus full-scale code transition (200 to 201) occurs at a voltage $\mathrm{V}_{\text {bIAs }}-\mathrm{V}_{\text {SWING }}+0.5$ LSBs.


Figure 5. ADC Transfer Function

## CONTROL REGISTER

The control register is 10 -bits wide and can only be written to. On power-on, all locations in the control register are automatically loaded with 0s. For the single channel AD7776, locations CR0 to CR6 of the control register are "don't cares." For the quad channel AD7777, locations CR2 and CR5 are "don't cares." Individual bit functions are described below.

CR0-CR2: Channel Address Locations. Determines which channel will be selected and converted for single channel operation. For simultaneous sampling operation CR0-CR2 holds the address of one of the two channels to be sampled.

## AD7776

| CR2 | CR1 | CR0 | Function |
| :--- | :--- | :--- | :--- |
| X $^{\star}$ | X | X | Select $A_{\text {IN }} 1$ |
| * $X=$ Don't Care |  |  |  |

## AD7777

| CR2 | CR1 | CR0 | Function |
| :--- | :--- | :--- | :--- |
| X $^{\star}$ | 0 | 0 | Select $A_{\text {IN }} 1$ |
| $\mathbf{X}$ | 0 | 1 | Select $A_{\text {IN }} 2$ |
| $\mathbf{X}$ | 1 | 0 | Select $A_{\text {IN }}^{3}$ |
| $\mathbf{X}$ | 1 | 1 | Select $A_{\text {IN }}{ }^{4}$ |
| $\star$ X $=$ Don't Care |  |  |  |

AD7778

| CR2 | CR1 | CR0 | Function |
| :--- | :--- | :--- | :--- |
| 0 | 0 | 0 | Select $A_{\text {IN }} 1$ |
| 0 | 0 | 1 | Select $A_{\text {IN }}{ }^{2}$ |
| 0 | 1 | 0 | Select $A_{\text {IN }}^{3}$ |
| 0 | 1 | 1 | Select $A_{\text {IN }}{ }^{4}$ |
| 1 | 0 | 0 | Select $A_{\text {II }} 5$ |
| 1 | 0 | 1 | Select $A_{\text {IN }} 6$ |
| 1 | 1 | 0 | Select $A_{\text {IN }} 7$ |
| 1 | 1 | 1 | Select $A_{\text {IN }} 8$ |

CR3-CR5: Channel Address Locations. Only applicable for simultaneous sampling with the AD7777 or AD7778 when CR3CR5 holds the address of the second channel to be sampled.

| AD7777 |  |  |  |
| :---: | :---: | :---: | :---: |
| CR5 | CR4 | CR3 | Function |
| X* | 0 | 0 | Select $\mathrm{A}_{\text {IN }} 1$ |
| X | 0 | 1 | Select $\mathrm{A}_{\text {IN }}{ }^{2}$ |
| X | 1 | 0 | Select $\mathrm{A}_{\text {IN }}{ }^{3}$ |
| X | 1 | 1 | Select $\mathrm{A}_{\text {IN }}{ }^{4}$ |


| AD7778 |  |  |  |
| :---: | :--- | :--- | :--- |
| CR5 | CR4 | CR3 | Function |
| 0 | 0 | 0 | Select $A_{\text {IN }} 1$ |
| 0 | 0 | 1 | Select $A_{\text {IN }} 2$ |
| 0 | 1 | 0 | Select $A_{\text {IN }} 3$ |
| 0 | 1 | 1 | Select $A_{\text {IN }} 4$ |
| 1 | 0 | 0 | Select $A_{\text {IN }} 5$ |
| 1 | 0 | 1 | Select $A_{\text {IN }} 6$ |
| 1 | 1 | 0 | Select $A_{\text {IN }} 7$ |
| 1 | 1 | 1 | Select $A_{\text {IN }} 8$ |

CR6: Determines whether operation is on a single channel or simultaneous sampling on two channels. Location CR6 is a "don't care" for the AD7776.

## CR6 Function

0 Single channel operation. Channel select address is contained in locations CR0-CR2.
1 Two channels simultaneously sampled and sequentially converted. Channel select addresses contained in locations CR0-CR2 and CR3-CR5.

CR7: Determines whether the device is in the normal operating mode or in the half-scale test mode.

CR7 Function<br>0 Normal Operating Mode

In the half-scale test mode REFIN is internally connected as an analog input(s). In this mode locations CR0-CR2 and CR3-CR5 are all "don't cares" since it is REFIN which will be converted. For the AD7777 and AD7778, the contents of location CR6 still determine whether a single or a double conversion is carried out on the REFIN level.

CR8: Determines whether the device is in the normal operating mode or in the power-down mode.

## CR8 Function <br> 0 Normal Operating Mode <br> 1 Power-down Mode

In the power-down mode all linear circuitry is turned off and the REFOUT output is pulled weakly ( $5 \mathrm{k} \Omega$ ) to AGND. The input impedance of the analog inputs and of the REFIN input remains the same in either normal mode or power-down mode. See under Circuit Description - Power-Down Mode.
CR9: Determines whether $\overline{\mathrm{BUSY}} / \overline{\mathrm{INT}}$ output flag goes low and remains low during conversion(s) or else goes low and remains low after the conversion(s) is (are) complete.

## CR9 $\overline{\text { BUSY/ }} / \overline{\text { INT }}$ Functionality

$0 \quad$ Output goes low and remains low during conversion(s).
1 Output goes low and remains low after conversion(s) is (are) complete.

## ADC Conversion Start Timing

Figure 6 shows the operating waveforms for the start of a conversion cycle. On the rising edge of $\overline{\mathrm{WR}}$, the conversion cycle starts with the acquisition and tracking of the selected ADC channel, $\mathrm{A}_{\text {IN }} 1-8$. The analog input voltage is held 40 ns (typically) after the first rising edge of CLKIN following four complete CLKIN cycles. If $\mathrm{t}_{\mathrm{D}}$ in Figure 6 is greater than 12 ns , then the falling edge of CLKIN as shown will be seen as the first falling clock edge. If $\mathrm{t}_{\mathrm{D}}$ is less than 12 ns , the first falling clock edge to be recognized will not occur until one cycle later.
Following the "hold" on the analog input(s), two complete CLKIN cycles are allowed for settling purposes before the MSB decision is made. The actual decision point occurs approximately 40 ns after the rising edge of CLKIN as shown in Figure 6. A further two CLKIN cycles are allowed for the second MSB decision. The succeeding bit decisions are made approximately 40 ns after each rising edge of CLKIN until the conversion is complete. At the end of conversion, if a single conversion has been requested $(\mathrm{CR} 6=0)$, the $\overline{\mathrm{BUSY}} / \overline{\mathrm{INT}}$ line changes

## AD7776/AD7717/AD7778

state (as programmed by CR9), and the SAR contents are transferred to the first register ADCREG1. The SAR is then reset in readiness for a new conversion. If simultaneous sampling has been requested $(C R 6=1)$, no change occurs in the status of the $\overline{\text { BUSY }} / \overline{\mathrm{INT}}$ output and the ADC automatically starts the second conversion. At the end of this conversion the $\overline{\mathrm{BUSY}} / \overline{\mathrm{INT}}$ line changes state (as programmed by CR9) and the SAR contents are transferred to the second register, ADCREG2.


Figure 6. ADC Conversion Start Timing

## Track-and-Hold

The track-and-hold (T/H) amplifiers on the analog input(s) of the AD7776/AD7777/AD7778 allow the ADC to accurately convert an input sine wave of 2 V peak-peak amplitude up to a frequency of 189 kHz , the Nyquist frequency of the ADC when operated at its maximum throughput rate of 378 kHz . This maximum rate of conversion includes conversion time and time between conversions. Because the input bandwidth of the track-and-hold is much greater than 189 kHz , the input signal should be band limited to avoid folding unwanted signals into the band of interest.

## Power-Down

The AD7776/AD7777/AD7778 can be placed in a power-down mode simply by writing a logic high to location CR8 of the control register. The following changes are effected immediately on writing a " 1 " to location CR8:

- Any conversion that is in progress is terminated.
- If a conversion is in progress, then the leading edge of $\overline{\mathrm{WR}}$ immediately drives the BUSY/INT output high.
- All the linear circuitry is turned off.
- The REFOUT output stops being driven and is pulled weakly ( $5 \mathrm{k} \Omega$ ) to analog ground.

Control inputs $\overline{\mathrm{CS}}, \overline{\mathrm{WR}}$ and $\overline{\mathrm{RD}}$ retain their purpose while the AD7776/AD7777/AD7778 is in power-down. If no conversions are in progress when the AD7776/AD7777/AD7778 is placed into the power-down modes, the contents of the ADC registers, ADCREG1 and ADCREG2, are retained during power-down and can be read as normal. On returning to normal operating mode a new conversion (or conversions, dependent on CR6) is automatically started. On completion, the invalid conversion results are loaded into the ADC registers losing the previous valid results.
In order to achieve the lowest possible power consumption in the power-down mode special attention must be paid to the state of the digital and analog inputs and outputs:

- Because each analog input channel sees a resistive divider to AGND, the input resistance of which does not change between normal and power-down modes, driving the analog input signals to 0 V or as close as possible to 0 V will minimize the power dissipated in the input signal conditioning circuitry.
- Similarly, the REFIN input sees a resistive divider to AGND, the input resistance of which does not change between normal and power-down modes. If an external reference is being used, then driving this reference input to 0 V or as close as possible to 0 V will minimize the power dissipated in the input signal conditioning circuitry.
- Since the REFOUT pin is pulled to AGND via, typically, a $5 \mathrm{k} \Omega$ resistor, any voltage above 0 V that this output may be pulled to by external circuitry will dissipate unnecessary power.
- Digital inputs $\overline{\mathrm{CS}}, \overline{\mathrm{WR}} \& \overline{\mathrm{RD}}$ should all be held at $\mathrm{V}_{\mathrm{CC}}$ or as close as possible. CLKIN should be held as close as possible to either 0 V or $\mathrm{V}_{\mathrm{CC}}$.
- Since the $\overline{\mathrm{BUSY}} / \overline{\mathrm{INT}}$ output is actively driven to a logic high, any loading on this pin to 0 V will dissipate power.
The AD7776/AD7777/AD7778 comes out of the power-down mode when a Logic " 0 " is written to location CR8 of the control register. Note that the contents of the other locations in the control register are retained when the device is placed in powerdown and are valid when power is restored. However coming out of power-down provides an opportunity to reload the complete contents of the control register without any extra instructions.


## Microprocessor Interfacing Circuits

The AD7776/AD7777/AD7778 family of ADCs is intended to interface to DSP machines such as the ADSP-2101, ADSP-2105, the TMS320 family and microcontrollers such as the 80 C 196 family.

Figure 7 shows the AD7776/AD7777/AD7778 interfaced to the TMS320C10@ 20.5 MHz and the TMS320C14@ 25 MHz . Figure 8 shows the interface with the TMS 320 C 25 @ 40 MHz . Note that one wait state is required with this interface. The ADSP-2101-50 and the ADSP-2105-40 interface is shown in Figure 9. One wait state is required with either of these machines.


Figure 7. AD7776/AD7777/AD7778 to TMS320C10 and TMS320C14 Interface


Figure 8. AD7776/AD7777/AD7778 to TMS320C25 Interface

Figure 10 shows the interface with the $80 \mathrm{C} 196 \mathrm{~KB} @ 12 \mathrm{MHz}$ and the $80 \mathrm{C} 196 \mathrm{KC} @ 16 \mathrm{MHz}$. One wait state is required with the 16 MHz machine. The 80 C 196 is configured to operate with a 16-bit multiplexed address/data bus.
Table I gives a truth table for the AD7776/AD7777/AD7778 and summarizes their microprocessor interfacing features. Note that a read instruction to any of the devices while a conversation is in progress will immediately stop that conversion and return unreliable data over the data bus.


Figure 9. AD7776/AD7777/AD7778 to ADSP-2101 and ADSP-2105 Interface


Figure 10. AD7776/AD7777/AD7778 to 80C196 Interface

Table I. AD7776/AD7777/AD7778 Truth Table for Microprocessor Interfacing

| $\overline{\overline{\mathbf{C S}}}$ | $\overline{\mathbf{R D}}$ | $\overline{\text { WR }}$ | DB0-DB9 | Function/Comments |
| :---: | :---: | :---: | :---: | :---: |
| 1 | X* | X* | High Z | Data Port High Impedance |
| 0 | 1 | 凹 | CR Data | Load control register (CR) data to control register and start a conversion. |
| 0 | 区 | 1 | ADC Data | ADC data placed on data bus. Depending upon location CR6 of the control register, one or two Read instructions will be required. |
|  |  |  |  | If CR6 is low, i.e., single channel conversion selected, a read instruction returns the contents of ADCREG1. Succeeding read instructions continue to return the contents of ADCREG1. |
|  |  |  |  | If CR6 is high, i.e., simultaneous sampling (double conversion) selected, the first read instruction returns the contents of ADCREG1 while the second read instruction returns the contents of ADCREG2. A third read instruction returns ADCREG1 again, the fourth ADCREG2, etc. |

* $\mathbf{X}=$ Don't Care


## DESIGN INFORMATION

## Layout Hints

Ensure that the layout for the printed circuit board has the digital and analog grounds separated as much as possible. Take care not to run any digital track alongside an analog signal track. Guard (screen) the analog input(s) with RTN.
Establish a single point analog ground separate from the logic system ground and as close as possible to the AD7776/AD7777/ AD7778. Both the RTN and AGND pins on the AD7776/ AD7777/AD7778 and all other signal grounds should be connected to this single point analog ground. In turn, this star ground should be connected to the digital ground at one point only-preferably at the low impedance power supply itself.

Low impedance analog and digital power supply common returns are important for correct operation of the devices, so make the foil width for these tracks as wide as possible.
In order to ensure a low impedance +5 V power supply at the actual $\mathrm{V}_{\mathrm{CC}}$ pin, it will be necessary to employ bypass capacitors from the pin itself to DGND. A $4.7 \mu \mathrm{~F}$ tantalum capacitor in parallel with a $0.1 \mu \mathrm{~F}$ ceramic capacitor is sufficient.

## ADC Corruption

Executing a read instruction to the AD7776/AD7777/AD7778 while a conversion is in progress will immediately halt the conversion and return invalid data over the data bus. The BUSY/ $\overline{\text { INT }}$ output pin should be monitored closely and all read instructions to the AD7776/AD7777/AD7778 prevented while this output shows that a conversion is in progress.
Executing a write instruction to the AD7776/AD7777/AD7778 while a conversion is in progress immediately halts the conversion, the falling edge of $\overline{\mathrm{WR}}$ driving the $\overline{\mathrm{BUSY}} / \overline{\mathrm{INT}}$ output high. The analog input(s) is sampled as normal and a new conversion sequence (dependent upon CR6) is started.

## ADC Conversion Time

Although each conversion takes only 14 CLKIN cycles, it can take between 4.5 to 5.5 CLKIN cycles to acquire the analog input(s) after the $\overline{\mathrm{WR}}$ input goes high and before any conversions start.

## TERMINOLOGY

## Relative Accuracy

For the AD7776, AD7777 and AD7778, relative accuracy or endpoint nonlinearity is the maximum deviation, in LSBs, of the ADC's actual code transition points from a straight line drawn between the endpoints of the ADC transfer function.

## Differential Nonlinearity

Differential nonlinearity is the difference between the measured change and the ideal 1 LSB change between any two adjacent codes. A specified maximum differential nonlinearity of $\pm 1$ LSB ensures no missed codes.

## Bias Offset Error

For an ideal 10 -bit ADC, the output code for an input voltage equal to $\mathrm{V}_{\text {bias }}$ should be midscale. The bias offset error is the difference between the actual midpoint voltage for midscale code and $\mathrm{V}_{\text {BIAS }}$, expressed in LSBs.

## Bias Offset Error Match

This is a measure of how closely the bias offset errors of all channels track each other. The bias offset error match of any channel must be no further away than 10 LSBs from the bias offset error of any other channel, regardless of whether the channels are independently sampled or simultaneously sampled.

## Plus and Minus Full-Scale Error

The input channels of the ADC can be considered as having bipolar (positive and negative) input ranges, but which are referred to $\mathrm{V}_{\text {BIAs }}$ (or REFIN) instead of AGND. Positive fullscale error for the ADC is the difference between the actual input voltage required to produce the plus full-scale code transition and the ideal input voltage ( $\mathrm{V}_{\text {BIAS }}+\mathrm{V}_{\text {SWING }}-1.5 \mathrm{LSB}$ ), expressed in LSBs. Minus full-scale error is similarly specified for the minus full-scale code transition, relative to the ideal input voltage for this transition $\left(\mathrm{V}_{\text {BIAS }}-\mathrm{V}_{\text {SWING }}+0.5 \mathrm{LSB}\right)$. Note that the full-scale errors for the ADC input channels are measured after their respective bias offset errors have been adjusted out.

## Plus and Minus Full-Scale Error Match

This is a measure of how closely the full-scale errors of all channels track each other. The full-scale error match of any channel must be no further away than 10 LSBs from the respective fullscale error of any other channel, regardless of whether the channels are independently sampled or simultaneously sampled.

## Short Circuit Current

This is defined as the maximum current which will flow either into or out of the REFOUT pin if this pin is shorted to any potential between 0 V and $\mathrm{V}_{\mathrm{CC}}$. This condition can be allowed for up to 10 seconds provided that the power dissipation of the package is not exceeded.
Signal-to-Noise and Distortion Ratio, $\mathbf{S} /(\mathbf{N}+\mathbf{D})$
Signal-to-noise and distortion ratio, $\mathrm{S} /(\mathrm{N}+\mathrm{D})$, is the ratio of the rms value of the measured input signal to the rms sum of all other spectral components below the Nyquist frequency, including harmonics but excluding dc. The value for $\mathrm{S} /(\mathrm{N}+\mathrm{D})$ is given in decibels.

## Total Harmonic Distortion, THD

Total harmonic distortion is the ratio of the rms sum of the first five harmonic components to the rms value of a full-scale input signal and is expressed in decibels. For the AD7776/AD7777/ AD7778, Total harmonic distortion (THD) is defined as:

$$
20 \log =\frac{\left(V 2^{2}+V 3^{2}+V 4^{2}+V 5^{2}+V 6^{2}\right)^{1 / 2}}{V_{1}}
$$

where $V_{1}$ is the rms amplitude of the fundamental and $V 2, V 3$, $V 4, V 5$ and $V 6$ are the rms amplitudes of the individual harmonics.

## Intermodulation Distortion, IMD

With inputs consisting of sine waves at two frequencies, fa and fb , any active device with nonlinearities will create distortion products, of order ( $\mathrm{m}+\mathrm{n}$ ), at sum and difference frequencies of $\mathrm{mfa}+\mathrm{nfb}$, where $\mathrm{m}, \mathrm{n}=0,1,2,3$. Intermodulation terms are those for which $m$ or $n$ is not equal to zero. For example, the second order terms include ( $\mathrm{fa}+\mathrm{fb}$ ) and ( $\mathrm{fa}-\mathrm{fb}$ ) and the third order terms include $(2 \mathrm{fa}+\mathrm{fb}),(2 \mathrm{fa}-\mathrm{fb}),(\mathrm{fa}+2 \mathrm{fb})$ and ( $\mathrm{fa}-2 \mathrm{fb}$ ).

## Channel-to-Channel Isolation

Channel-to-channel isolation is a measure of the level of crosstalk between channels. It is measured by applying a fullscale 100 kHz sine wave signal to any one of the input channels and monitoring the remaining channels. The figure given is the worst case across all channels.

## DIGITAL SIGNAL PROCESSING APPLICATIONS

In digital signal processing (DSP) application areas like voice recognition, echo cancellation and adaptive filtering, the dynamic characteristics $\mathrm{S} /(\mathrm{N}+\mathrm{D})$, THD \& IMD of the ADC are critical. The AD7776/AD7777/AD7778 are specified dynamically as well as with standard dc specifications. Because the track/hold amplifier has a wide bandwidth, an antialiasing filter should be placed on the analog inputs to avoid aliasing of high frequency noise back into the bands of interest.
The dynamic performance of the ADC is evaluated by applying a sine wave signal of very low distortion to a single analog input which is sampled at a 380.95 kHz sampling rate. A fast Fourier transform (FFT) plot or histogram plot is then generated from which the signal to noise and distortion, harmonic distortion and dynamic differential nonlinearity data can be obtained. Similarly, for intermodulation distortion, an input signal consisting of two pure sine waves at different frequencies is applied to the AD7776/AD7777/AD7778.

Figure 11 shows a 2048 point FFT plot for a single channel of the AD7778 with an input signal of 99.88 kHz . The SNR is 58.71 dB . It can be seen that most of the harmonics are buried in the noise floor. It should be noted that the harmonics are taken into account when calculating the $\mathrm{S} /(\mathrm{N}+\mathrm{D})$.


Figure 11. ADC FFT Plot
The relationship between $\mathrm{S} /(\mathrm{N}+\mathrm{D}$ ) and resolution ( $n$ ) is expressed by the following equation:

$$
S /(N+D)=(6.02 n+1.76) d B
$$

This is for an ideal part with no differential or integral linearity errors. These errors will cause a degradation in $\mathrm{S} /(\mathrm{N}+\mathrm{D})$. By working backwards from the above equation, it is possible to get a measure of ADC performance expressed in effective number of bits ( n ).

$$
n(\text { effective })=\frac{S /(N+D)(d B)-1.76}{6.02}
$$

The effective number of bits plotted vs. frequency for a single channel of the AD7778 is shown in Figure 12. The effective number of bits is typically 9.5 .


Figure 12. Effective Number of Bits vs. Frequency

## FEATURES

4- or 8-Analog Input Channels Built-In Track/Hold Function 10kHz Signal Handling on Each Channel Fast Microprocessor Interface Single +5V Supply
Low Power: 50 mW
Fast Conversion Rate, 2.5 $\mu \mathrm{s} /$ Channel
Tight Error Specification: 1/2LSB

## GENERAL DESCRIPTION

The AD7824 and AD7828 are high-speed, multichannel, 8-bit ADCs with a choice of 4 (AD7824) or 8 (AD7828) multiplexed analog inputs. A half-flash conversion technique gives a fast conversion rate of $2.5 \mu \mathrm{~s}$ per channel and the parts have a built-in track/hold function capable of digitizing full-scale signals of $10 \mathrm{kHz}(157 \mathrm{mV} / \mu \mathrm{s}$ slew rate) on all channels. The AD7824 and AD7828 operate from a single +5 V supply and have an analog input range of 0 to +5 V , using an external +5 V reference.
Microprocessor interfacing of the parts is simple, using standard Chip Select $(\overline{\mathrm{CS}})$ and Read ( $\overline{\mathrm{RD}}$ ) signals to intitiate the conversion and read the data from the three-state data outputs. The half-flash conversion technique means that there is no need to generate a clock signal for the ADC. The AD7824 and AD7828 can be interfaced easily to most popular microprocessors.
The AD7824 and AD7828 are fabricated in an advanced, all ion-implanted, Linear-Compatible CMOS process (LC ${ }^{2}$ MOS) and have low power dissipation of 40 mW (typ). The AD7824 is available in a 0.3 " wide, 24 -pin "skinny" DIP, while the AD7828 is available in a $0.6^{\prime \prime}$ wide, 28 -pin DIP and in 28 -terminal surface mount packages.

FUNCTIONAL BLOCK DIAGRAM

-AD7824 - 4-CHANNEL MUX


## PRODUCT HIGHLIGHTS

1. 4- or 8 -channel input multiplexer gives cost-effective spacesaving multichannel ADC system.
2. Fast conversion rate of $2.5 \mu \mathrm{~s} /$ channel features a per channel sampling frequency of 100 kHz for the AD7824 or 50 kHz for the AD7828.
3. Built-in track-hold function allows handling of 4 or 8 -channels up to 10 kHz bandwidth ( $157 \mathrm{mV} / \mu \mathrm{s}$ slew rate).
4. Tight total unadjusted error spec and channel-to-channel matching eliminate the need for user trims.
5. Single +5 V supply simplifies system power requirements.
6. Fast, easy-to-use digital interface allows connection to most popular microprocessors with minimal external components. No clock signal is required for the ADC.

SPEC|F|CATIONS $\left(v_{D D}=+5 v, v_{\text {REF }}(+)=+5 V, v_{\text {REF }}(-)=G N D=0 V\right.$ unless otherwise
AD7824/AD7828
noted. All specifications $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ unless otherwise noted. Specifications apply for Mode $\mathbf{0}$.)

| Parameter | K Version ${ }^{1}$ | L Version | B, T Versions | C, U Versions | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ACCURACY <br> Resolution <br> Total Unadjusted Error ${ }^{2}$ Minimum Resolution for which No Missing Codes are guaranteed Channel to Channel Mismatch | $\begin{aligned} & 8 \\ & \pm 1 \\ & 8 \\ & \pm 1 / 4 \end{aligned}$ | $\begin{aligned} & 8 \\ & \pm 1 / 2 \\ & 8 \\ & \pm 1 / 4 \end{aligned}$ | $\begin{aligned} & 8 \\ & \pm 1 \\ & 8 \\ & \pm 1 / 4 \end{aligned}$ | $\begin{aligned} & 8 \\ & \pm 1 / 2 \\ & 8 \\ & \pm 1 / 4 \end{aligned}$ | Bits <br> LSB max <br> Bits <br> LSB max |  |
| REFERENCE INPUT <br> Input Resistance <br> $\mathbf{V}_{\text {REF }}(+$ ) Input Voltage Range <br> $\mathbf{V}_{\text {REF }}(-)$ Input Voltage Range | $\begin{aligned} & 1.0 / 4.0 \\ & \mathbf{V}_{\text {REF }}(-) / \\ & \mathbf{V}_{\mathrm{DD}} \\ & \mathbf{G N D} / \\ & \mathbf{V}_{\text {REF }}(+) \end{aligned}$ | $\begin{aligned} & 1.0 / 4.0 \\ & \mathbf{V}_{\text {REF }}(-) / \\ & \mathrm{V}_{\mathrm{DD}} \\ & \text { GND/ } \\ & \mathrm{V}_{\text {REF }}(+) \\ & \hline \end{aligned}$ | $\begin{aligned} & 1.0 / 4.0 \\ & \mathbf{V}_{\text {REF }}(-) / \\ & \mathrm{V}_{\mathrm{DD}} \\ & \text { GND } / \\ & \mathbf{V}_{\text {REF }}(+) \end{aligned}$ | $\begin{aligned} & 1.0 / 4.0 \\ & \mathbf{V}_{\text {REF }}(-) / \\ & \mathbf{V}_{\mathrm{DD}} \\ & \text { GND } / \\ & \mathbf{V}_{\text {REF }}(+) \end{aligned}$ | $\mathrm{k} \Omega$ min $/ \mathrm{k} \Omega$ max <br> $V_{\min } / V_{\text {max }}$ <br> $\mathrm{V} \min / \mathrm{V}_{\text {max }}$ |  |
| ANALOG INPUT <br> Input Voltage Range <br> Input Leakage Current Input Capacitance ${ }^{3}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{REF}}(-) / \\ & \mathrm{V}_{\mathrm{REF}}(+) \\ & \pm 3 \\ & \mathbf{4 5} \end{aligned}$ | $\begin{aligned} & \mathbf{V}_{\mathrm{REF}}(-) / \\ & \mathbf{V}_{\mathrm{REF}}(+) \\ & \pm 3 \\ & 45 \end{aligned}$ | $\begin{aligned} & \mathbf{V}_{\mathrm{REF}( }(-) / \\ & \mathbf{V}_{\mathrm{REF}}(+) \\ & \pm 3 \\ & \mathbf{4 5} \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{REF}}(-) / \\ & \mathrm{V}_{\mathrm{REF}}(+) \\ & \pm 3 \\ & 45 \end{aligned}$ | $\mathrm{V} \min / V$ max <br> $\mu$ A max <br> pF typ | Analog Input Any Channel $0 \text { to }+5 \mathrm{~V}$ |
| LOGICINPUTS RD, $\overline{\mathrm{CS}}, \mathrm{A} 0, \mathrm{~A} 1 \& A 2$ $\mathrm{~V}_{\text {INH }}$ $\mathbf{V}_{\text {INL }}$ $\mathrm{I}_{\text {INH }}$ $\mathrm{I}_{\text {INL }}$ Input Capacitance $^{3}$ | $\begin{aligned} & 2.4 \\ & 0.8 \\ & 1 \\ & -1 \\ & 8 \end{aligned}$ | $\begin{aligned} & 2.4 \\ & 0.8 \\ & 1 \\ & -1 \\ & 8 \end{aligned}$ | $\begin{aligned} & 2.4 \\ & 0.8 \\ & 1 \\ & -1 \end{aligned}$ | $\begin{aligned} & 2.4 \\ & 0.8 \\ & 1 \\ & -1 \\ & 8 \end{aligned}$ | V min $V$ max $\mu A$ max $\mu$ A max pF max | Typically 5pF |
|  | $\begin{aligned} & 4.0 \\ & 0.4 \\ & \pm 3 \\ & 8 \\ & \\ & 0.4 \\ & \pm 3 \\ & 8 \end{aligned}$ | $\begin{aligned} & 4.0 \\ & 0.4 \\ & \pm 3 \\ & 8 \\ & \\ & 0.4 \\ & \pm 3 \end{aligned}$ | $\begin{aligned} & 4.0 \\ & 0.4 \\ & \pm 3 \\ & 8 \\ & 0.4 \\ & \pm 3 \\ & 8 \end{aligned}$ | $\begin{aligned} & 4.0 \\ & 0.4 \\ & \pm 3 \\ & 8 \\ & \\ & 0.4 \\ & \pm 3 \\ & 8 \end{aligned}$ | $V_{\text {min }}$ <br> $V$ max <br> $\mu$ A max <br> pF max <br> $V_{\text {max }}$ <br> $\mu A$ max <br> pF max | $I_{\text {SOURCE }}=360 \mu \mathrm{~A}$ <br> $\mathrm{I}_{\mathrm{SINK}}=1.6 \mathrm{~mA}$ <br> Floating State Leakage <br> Typically 5pF <br> $\mathrm{I}_{\mathrm{SINK}}=2.6 \mathrm{~mA}$ <br> Floating State Leakage <br> Typically 5pF |
| SLEW RATE, TRACKING ${ }^{3}$ | $\begin{aligned} & \hline 0.7 \\ & 0.157 \end{aligned}$ | $\begin{aligned} & \hline 0.7 \\ & 0.157 \end{aligned}$ | $\begin{aligned} & \hline 0.7 \\ & 0.157 \end{aligned}$ | $\begin{aligned} & \hline 0.7 \\ & 0.157 \end{aligned}$ | V/ $/$ styp <br> V/us max |  |
| POWER SUPPLY <br> $V_{D D}$ <br> $I_{D D}{ }^{5}$ <br> Power Dissipation <br> Power Supply Sensitivity | $\begin{aligned} & 5 \\ & 16 \\ & 50 \\ & 80 \\ & \pm 1 / 4 \end{aligned}$ | 16 <br> 50 <br> 80 <br> $\pm 1 / 4$ | $\begin{aligned} & 5 \\ & 20 \\ & 50 \\ & 100 \\ & \pm 1 / 4 \end{aligned}$ | $\begin{aligned} & 5 \\ & 20 \\ & 50 \\ & 100 \\ & \pm 1 / 4 \end{aligned}$ | Volts <br> mA max mW typ mW max LSB max | $\pm 5 \%$ for Specified Performance $\overline{\mathrm{CS}}=\overline{\mathrm{RD}}=2.4 \mathrm{~V}$ <br> $\pm 1 / 16$ LSB typ <br> $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \%$ |

## NOTES

${ }^{1}$ Temperature Ranges are as follows:
K, L Versions; 0 to $+70^{\circ} \mathrm{C}$
B, CVersions; $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
T, U Versions; $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
${ }^{2}$ Total Unadjusted Error includes offset, full-scale and linearity errors.
${ }^{3}$ Sample tested at $25^{\circ} \mathrm{C}$ by Product Assurance to ensure compliance.
${ }^{4}$ RDY is an open drain output.
${ }^{5}$ See Typical Performance Characteristics.
Specifications subject to change without notice.

TIMING CHARACTERISTICS ${ }^{1}$
$\left(V_{D D}=+5 V^{\prime} V_{R E}(+)=+5 V ; V_{R E}(-)=G N D=O V\right.$ unless otherwise stated $)$

| Parameter | Limit at $25^{\circ} \mathrm{C}$ <br> (All Grades) | Limit at $\mathbf{T}_{\min }, \mathbf{T}_{\max }$ <br> (K, L, B, C Grades) | Limit at $\mathbf{T}_{\text {min }}, \mathbf{T}_{\text {max }}$ <br> (T, U Grades) | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\mathrm{css}}$ | 0 | 0 | 0 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{RD}}$ Setup Time |
| $\mathrm{t}_{\mathrm{CSH}}$ | 0 | 0 | 0 | ns min | $\overline{\mathrm{CS}}$ to $\overline{\mathrm{RD}}$ Hold Time |
| $\mathrm{t}_{\text {AS }}$ | 0 | 0 | 0 | ns min | Multiplexer Address Setup Time |
| $\mathrm{t}_{\text {AH }}$ | 30 | 35 | 40 | ns min | Multiplexer Address Hold Time |
| $\mathrm{t}_{\mathrm{RDY}}{ }^{2}$ | 40 | 60 | 60 | ns max | $\overline{\mathrm{CS}}$ to RDY Delay. Pull-Up Resistor $5 \mathrm{k} \Omega$. |
| $\mathrm{t}_{\text {CRD }}$ | 2.0 | 2.4 | 2.8 | $\mu \mathrm{s}$ max | Conversion Time, Mode 0 |
| $\mathrm{t}_{\mathrm{ACCl}}{ }^{3}$ | 85 | 110 | 120 | ns max | Data Access Time after $\overline{\mathrm{RD}}$ |
| $\mathrm{t}_{\mathrm{ACC}}{ }^{3}$ | 50 | 60 | 70 | ns max | Data Access Time after INT, Mode 0 |
| $\mathrm{t}_{\mathrm{INTH}}{ }^{2}$ | 40 | 65 | 70 | ns typ | $\overline{\mathrm{RD}}$ to INT Delay |
|  | 75 | 100 | 100 | ns max |  |
| $\mathrm{t}_{\mathrm{DH}}{ }^{4}$ | 60 | 70 | 70 | ns max | Data Hold Time |
| $\mathrm{t}_{\mathrm{p}}$ | 500 | 500 | 600 | ns min | Delay Time between Conversions |
| $\mathrm{t}_{\mathrm{RD}}$ | 60 600 | 80 500 | $80$ $400$ | ns min ns max | Read Pulse Width, Mode 1 |

NOTES
${ }^{\prime}$ Sample tested at $25^{\circ} \mathrm{C}$ to ensure compliance. All input control signals are specified with $\mathrm{tr}=\mathrm{tf}=20 \mathrm{~ns}(10 \%$ to $90 \%$ of $+5 \mathrm{~V})$ and timed from a voltage level of 1.6 V .
${ }^{2} \mathrm{C}_{\mathrm{t}}=50 \mathrm{pF}$.
${ }^{3}$ Measured with load circuits of Figure 1 and defined as the time required for an output to cross 0.8 V or 2.4 V .
${ }^{4}$ Defined as the time required for the data lines to change 0.5 V when loaded with the circuits of Figure 2.
Specifications subject to change without notice.

| AD7824 |  | AD7828 |  |  |  |
| :--- | :--- | :--- | :--- | :--- | :--- |
| A1 | A0 | A2 | A1 | A0 |  |
| 0 | 0 | 0 | 0 | 0 | AIN 1 |
| 0 | 1 | 0 | 0 | 1 | AIN 2 |
| 1 | 0 | 0 | 1 | 0 | AIN 3 |
| 1 | 1 | 0 | 1 | 1 | AIN 4 |
|  |  | 1 | 0 | 0 | AIN 5 |
|  |  | 1 | 0 | 1 | AIN 6 |
|  |  | 1 | 1 | 0 | AIN 7 |
|  |  | 1 | 1 | 1 | AIN 8 |

Table I. Truth Table for Input Channel Selection


Figure 1. Mode 0 Timing Diagram

## ABSOLUTE MAXIMUM RATINGS*

( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)

| V ${ }_{\text {DD }}$. . . . . . . . . . . . . . . . . . . . . . . . 0 OV , +7V |  |
| :---: | :---: |
| Digital Input Voltage to GND |  |
| ( $\overline{\mathrm{RD}}, \overline{\mathrm{CS}}, \mathrm{A} 0, \mathrm{~A} 1 \& \mathrm{~A} 2)$ | $-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| Digital Output Voltage to GND |  |
| $\mathrm{V}_{\text {REF }}(+)$ to GND . . . . . . . $\mathrm{V}_{\text {REF }}(-), \mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |  |
| $\mathrm{V}_{\mathbf{R E F}}$ ( - ) to GND . . . . . . . . . . . . . . $0 \mathrm{~V}, \mathrm{~V}_{\text {REF }}(+)$ |  |
| Analog Input (Any Channel) |  |
| Operating Temperature Range |  |
| Commercial (K, L Versions) | 0 t |

Industrial (B, C Versions) . . . . . . . . $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Extended (T, U Versions) . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10secs) . . . . . . . . $+300^{\circ} \mathrm{C}$
Power Dissipation (Any Package) to $+75^{\circ} \mathrm{C}$. . . . . 450 mW
Derates above $+75^{\circ} \mathrm{C}$ by . . . . . . . . . . . . . . . $6 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective


## LCCC

PIN CONFIGURATIONS


NC = NO CONNECT


ORDERING GUIDE

| Model | Temperature Range | Total Unadjusted Error(LSBs) | Package Option ${ }^{1}$ |
| :---: | :---: | :---: | :---: |
| AD7824KN | 0 to $+70^{\circ} \mathrm{C}$ | $\pm 1$ | N -24 |
| AD7824LN | 0 to $+70^{\circ} \mathrm{C}$ | $\pm 1 / 2$ | N-24 |
| AD7824KR | 0 to $+70^{\circ} \mathrm{C}$ | $\pm 1$ | R-24 |
| AD7824BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1$ | Q-24 |
| AD7824CQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1 / 2$ | Q-24 |
| AD7824TQ ${ }^{2}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\pm 1$ | Q-24 |
| AD7824UQ ${ }^{2}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\pm 1 / 2$ | Q-24 |
| AD7828KN | 0 to $+70^{\circ} \mathrm{C}$ | $\pm 1$ | N-28 |
| AD7828LN | 0 to $+70^{\circ} \mathrm{C}$ | $\pm 1 / 2$ | N-28 |
| AD7828KP | 0 to $+70^{\circ} \mathrm{C}$ | $\pm 1$ | P-28A |
| AD7828LP | 0 to $+70^{\circ} \mathrm{C}$ | $\pm 1 / 2$ | P-28A |
| AD7828BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1$ | Q-28 |
| AD7828CQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1 / 2$ | Q-28 |
| AD7828TQ ${ }^{2}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\pm 1$ | Q-28 |
| AD7828UQ ${ }^{2}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\pm 1 / 2$ | Q-28 |
| AD7828TE ${ }^{2}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\pm 1$ | E-28A |
| AD7828UE ${ }^{2}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\pm 1 / 2$ | E-28A |

## NOTES

${ }^{1} \mathrm{~N}=$ Plastic DIP; $\mathbf{Q}=$ Hermetic DIP, R = Small Outline IC; $\mathbf{P}=$ Plastic Leaded Chip Carrier; E = Leadless Ceramic Chip Carrier. For outline information see Package Information section.
${ }^{2}$ Available to $/ 883 \mathrm{~B}$ processing only. Contact our local sales office for military data sheet. For U.S. Standard Military Drawing (SMD) see DESC Drawing \#5692-88764.

## FEATURES

## Complete 12-Bit I/O System, Comprising: 12-Bit ADC with Track/Hold Amplifier 83 kHz Throughput Rate 72 dB SNR <br> 12-Bit DAC with Output Amplifier $3 \mu \mathrm{~s}$ Settling Time 72 dB SNR <br> On-Chip Voltage Reference <br> Operates from $\pm 5$ V Supplies <br> Low Power - 130 mW typ <br> Small 0.3" Wide DIP <br> APPLICATIONS <br> Digital Signal Processing <br> Speech Recognition and Synthesis <br> Spectrum Analysis <br> High Speed Modems <br> DSP Servo Control

## GENERAL DESCRIPTION

The AD7868 is a complete 12 -bit I/O system containing a DAC and an ADC. The ADC is a successive approximation type with a track-and-hold amplifier having a combined throughput rate of 83 kHz . The DAC has an output buffer amplifier with a settling time of $3 \mu$ s to 12 bits. Temperature compensated 3 V buried Zener references provide precision references for the DAC and ADC.
Interfacing to both the DAC and ADC is serial, minimizing pin count and giving a small 24 -pin package size. Standard control signals allow serial interfacing to most DSP machines. Asynchronous ADC conversion control and DAC updating is made possible with the $\overline{\text { CONVST }}$ and $\overline{\text { LDAC }}$ logic inputs.
The AD7868 operates from $\pm 5 \mathrm{~V}$ power supplies, the analog input/output range of the ADC/DAC is $\pm 3 \mathrm{~V}$. The part is fully specified for dynamic parameters such as signal-to-noise ratio and harmonic distortion as well as traditional dc specifications.
The part is available in a 24 -pin, $0.3^{\prime \prime}$ wide, plastic or hermetic dual-in-line package (DIP) and in a 28 -pin, plastic SOIC package.

FUNCTIONAL BLOCK DIAGRAM


## PRODUCT HIGHLIGHTS

1. Complete 12-Bit I/O System.

The AD7868 contains a 12 -bit ADC with a track-and-hold amplifier and a 12 -bit DAC with output amplifier. Also included are separate on-chip voltage references for the DAC and the ADC.
2. Dynamic Specifications for DSP Users.

In addition to traditional dc specifications, the AD7868 is specified for ac parameters including signal-to-noise ratio and harmonic distortion. These parameters along with important timing parameters are tested on every device.
3. Small Package.

The AD7868 is available in a 24 -pin DIP and a 28 -pin SOIC package.

[^73]AD7868


| Parameter | $\begin{aligned} & \mathbf{A} \\ & \text { Version }^{1} \end{aligned}$ | $\begin{aligned} & \text { B } \\ & \text { Version }^{1} \end{aligned}$ | $\begin{aligned} & \mathbf{T} \\ & \text { Version }^{1} \end{aligned}$ | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DYNAMIC PERFORMANCE ${ }^{2}$ |  |  |  |  |  |
| Signal-to-Noise Ratio ${ }^{3,4}$ (SNR)@ $+25^{\circ} \mathrm{C}$ | 70 | 72 | 70 | dB min | $\mathrm{V}_{\mathrm{IN}}=10 \mathrm{kHz}$ Sine Wave, $\mathrm{f}_{\text {SAMPLE }}=83 \mathrm{kHz}$ |
| $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ | 70 | 71 | 70 | dB min | Typically 71.5 dB for $0<\mathrm{V}_{\text {IN }}<41.5 \mathrm{kHz}$ |
| Total Harmonic Distortion (THD) | -78 | $-78$ | -76 | dB max | $\mathrm{V}_{\mathrm{IN}}=10 \mathrm{kHz}$ Sine Wave, $\mathrm{f}_{\text {SAMPLE }}=83 \mathrm{kHz}$ |
| Peak Harmonic or Spurious Noise | -78 | -78 | -76 | $\mathrm{dB} \max$ | Typically -84 dB for $0<\mathrm{V}_{\mathrm{IN}}<41.5 \mathrm{kHz}$ $\mathrm{V}_{\text {IN }}=10 \mathrm{kHz}$ Sine Wave, $\mathrm{f}_{\text {SAMPLE }}=83 \mathrm{kHz}$ Typically -84 dB for $0<\mathrm{V}_{\mathrm{IN}}<41.5 \mathrm{kHz}$ |
| Intermodulation Distortion (IMD) |  |  |  |  |  |
| Second Order Terms | -78 | -78 | -76 | $\mathrm{dB} \max$ | $\mathrm{fa}=9 \mathrm{kHz}, \mathrm{fb}=9.5 \mathrm{kHz}, \mathrm{f}_{\mathrm{SAMPLE}}=50 \mathrm{kHz}$ |
| Third Order Terms | -80 | -80 | -78 | $\mathrm{dB} \max$ | $\mathrm{fa}=9 \mathrm{kHz}, \mathrm{fb}=9.5 \mathrm{kHz}, \mathrm{f}_{\mathrm{SAMPLE}}=50 \mathrm{kHz}$ |
| Track/Hold Acquisition Time | 2 | 2 | 2 | $\mu s$ max |  |
| $\overline{\mathrm{DC}}$ ACCURACY |  |  |  |  |  |
| Resolution | 12 | 12 | 12 | Bits |  |
| Minimum Resolution for Which |  |  |  |  |  |
| No Missing Codes Are Guaranteed | 12 | 12 | 12 | Bits |  |
| Integral Nonlinearity | $\pm 1 / 2$ | $\pm 1 / 2$ | $\pm 1 / 2$ | LSB typ |  |
| Integral Nonlinearity |  | $\pm 1$ | $\pm 1$ | LSB max |  |
| Differential Nonlinearity | $\pm 0.9$ | $\pm 0.9$ | $\pm 0.9$ | LSB max |  |
| Bipolar Zero Error | $\pm 5$ | $\pm 5$ | $\pm 5$ | LSB max |  |
| Positive Gain Error ${ }^{5}$ | $\pm 5$ | $\pm 5$ | $\pm 5$ | LSB max |  |
| Negative Gain Errors | $\pm 5$ | $\pm 5$ | $\pm 5$ | LSB max |  |
| ANALOG INPUT |  |  |  |  |  |
| Input Voltage Range | $\pm 3$ | $\pm 3$ | $\pm 3$ | Volts |  |
| Input Current | $\pm 1$ | $\pm 1$ | $\pm 1$ | mA max |  |
| REFERENCE OUTPUT ${ }^{6}$ |  |  |  |  |  |
| RO ADC@+25 ${ }^{\circ} \mathrm{C}$ | 2.99/3.01 | 2.99/3.01 | 2.99/3.01 | $V \min / V \max$ |  |
| RO ADC TC | $\pm 25$ | $\pm 25$ | $\pm 25$ | ppm $/{ }^{\circ} \mathrm{C}$ typ |  |
| RO ADC TC |  | $\pm 40$ | $\pm 50$ | ppm/ ${ }^{\circ} \mathrm{C}$ max |  |
| Reference Load Sensitivity ( $\triangle$ RO ADC vs. $\Delta \mathrm{I}$ ) | $-1.5$ | -1.5 | $-1.5$ | mV max | Reference Load Current Change ( $0-500 \mu \mathrm{~A}$ ), Reference Load Should Not Be Changed During Conversion |
| LOGIC INPUTS |  |  |  |  |  |
| (CONVST, CLK, CONTROL) |  |  |  |  |  |
| Input High Voltage, $\mathrm{V}_{\text {INH }}$ | 2.4 | 2.4 | 2.4 | $V$ min | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \%$ |
| Input Low Voltage, $\mathrm{V}_{\text {INL }}$ | 0.8 | 0.8 | 0.8 | V max | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \%$ |
| Input Current, $\mathrm{I}_{\mathbf{I N}}$ | $\pm 10$ | $\pm 10$ | $\pm 10$ | $\mu \mathrm{A}$ max | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}$ |
| Input Current ${ }^{7}$ (CONTROL Input Only) | $\pm 10$ | $\pm 10$ | $\pm 10$ | $\mu \mathrm{A}$ max | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\text {Ss }}$ to DGND |
| Input Capacitance, $\mathrm{C}_{\mathrm{IN}}{ }^{8}$ | 10 | 10 | 10 | pF max |  |
| LOGIC OUTPUTS |  |  |  |  |  |
| DR, RFS Outputs |  |  |  |  |  |
| Output Low Voltage, $\mathrm{V}_{\text {OL }}$ | 0.4 | 0.4 | 0.4 | V max | $\mathrm{I}_{\text {SINK }}=1.6 \mathrm{~mA}$, Pull-Up Resistor $=4.7 \mathrm{k} \Omega$ |
| RCLK Output |  |  |  |  |  |
| Output Low Voltage, $\mathrm{V}_{\text {OL }}$ | 0.4 | 0.4 | 0.4 | V max | $\mathrm{I}_{\text {SINK }}=2.6 \mathrm{~mA}$, Pull-Up Resistor $=2 \mathrm{k} \Omega$ |
| DR, RFS, RCLK Outputs |  |  |  |  |  |
| Floating-State Leakage Current | $\pm 10$ | $\pm 10$ | $\pm 10$ | $\mu \mathrm{A}$ max |  |
| Floating-State Output Capacitance ${ }^{8}$ | 15 | 15 | 15 | pF max |  |
| CONVERSION TIME |  |  |  |  |  |
| External Clock | 10 | 10 | 10 | $\mu s$ max |  |
| Internal Clock | 10 | 10 | 10 | $\mu s \max$ | The Internal Clock Has a Nominal Value of 2.0 MHz |
| POWER REQUIREMENTS |  |  |  |  | For Both DAC and ADC |
| $V_{\text {DD }}$ | +5 | +5 | +5 | V nom | $\pm 5 \%$ for Specified Performance |
| $\mathrm{V}_{\text {SS }}$ | -5 | -5 | -5 | $V$ nom | $\pm 5 \%$ for Specified Performance |
| $\mathrm{I}_{\text {DD }}$ | 22 | 22 | 25 | $m A \max$ | Cumulative Current from the Two $\mathrm{V}_{\text {DD }}$ Pins |
| $\mathrm{I}_{\text {SS }}$ | 12 | 12 | 13 | mA max | Cumulative Current from the Two $\mathrm{V}_{\text {Ss }}$ Pins |
| Total Power Dissipation | 170 | 170 | 190 | mW max | Typically 130 mW |

[^74]DAC SECTION $V_{D O}=+5 V \pm 5 \%, V_{S S}=-5 V \pm 5 \%$, $\operatorname{AGND}=$ DGND $=0 \mathrm{~V}$, RI DAC $=+3 \mathbf{V}$ and decoupled as shown in Figure 2, $\mathrm{V}_{\text {out }}$ Load to $A G N D ; \mathrm{R}_{\mathrm{L}}=\mathbf{2 k \Omega}, \mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}$. All specifications $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ unless otherwise noted.)

| Parameter | $\begin{aligned} & \mathbf{A} \\ & \text { Version }^{1} \end{aligned}$ | $\begin{aligned} & \hline \text { B } \\ & \text { Version }^{1} \end{aligned}$ | $\begin{aligned} & \mathbf{T} \\ & \text { Version }{ }^{1} \end{aligned}$ | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DYNAMIC PERFORMANCE ${ }^{2}$ |  |  |  |  |  |
| Signal to Noise Ratio ${ }^{3}$ (SNR) @ $+25^{\circ} \mathrm{C}$ | 70 | 72 | 70 | dB min | $\mathrm{V}_{\text {OUT }}=1 \mathrm{kHz}$ Sine $\mathrm{W}_{\text {ave, }} \mathrm{f}_{\text {SAMPLE }}=83 \mathrm{kHz}$ |
| $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ | 70 | 71 | 70 | dB min | Typically 71.5 dB at $+25^{\circ} \mathrm{C}$ for $0<\mathrm{V}_{\text {OuT }}<20 \mathrm{kHz}^{4}$ |
| Total Harmonic Distortion (THD) | -78 | -78 | -76 | dB max | $\mathrm{V}_{\text {OUT }}=1 \mathrm{kHz}$ Sine Wave, $\mathrm{f}_{\text {SAMPLE }}=83 \mathrm{kHz}$ <br> Typically -84 dB at $+25^{\circ} \mathrm{C}$ for $0<\mathrm{V}_{\text {OUT }}<20 \mathrm{kHz}^{4}$ |
| Peak Harmonic or Spurious Noise | -78 | -78 | -76 | dB max | $\mathrm{V}_{\text {OUT }}=1 \mathrm{kHz}, \mathrm{f}_{\text {SAMPLE }}=83 \mathrm{kHz}$ <br> Typically -84 dB at $+25^{\circ} \mathrm{C}$ for $0<\mathrm{V}_{\text {OuT }}<20 \mathrm{kHz}^{4}$ |
| DC ACCURACY |  |  |  |  |  |
| Resolution | 12 | 12 | 12 | Bits |  |
| Integral Nonlinearity | $\pm 1 / 2$ | $\pm 1 / 2$ | $\pm 1 / 2$ | LSB typ |  |
| Integral Nonlinearity |  | $\pm 1$ | $\pm 1$ | LSB max |  |
| Differential Nonlinearity | $\pm 0.9$ | $\pm 0.9$ | $\pm 0.9$ | LSB max | Guaranteed Monotonic |
| Bipolar Zero Error | $\pm 5$ | $\pm 5$ | $\pm 5$ | LSB max |  |
| Positive Full-Scale Errors | $\pm 5$ | $\pm 5$ | $\pm 5$ | LSB max |  |
| Negative Full-Scale Error ${ }^{5}$ | $\pm 5$ | $\pm 5$ | $\pm 5$ | LSB max |  |
| REFERENCE OUTPUT ${ }^{6}$ |  |  |  |  |  |
| RO DAC @ $+25^{\circ} \mathrm{C}$ | 2.99/3.01 | 2.99/3.01 | 2.99/3.01 | V min/V max |  |
| RO DAC TC | $\pm 25$ | $\pm 25$ | $\pm 25$ | ppm $/{ }^{\circ} \mathrm{C}$ typ |  |
| RO DAC TC |  | $\pm 40$ | $\pm 50$ | ppm/ ${ }^{\circ} \mathrm{C}$ max |  |
| Reference Load Change ( $\Delta$ RO DAC vs. $\Delta \mathrm{I}$ ) | -1.5 | -1.5 | - 1.5 |  | Reference Load Current Change (0-500 $\mu \mathrm{A}$ ) |
| REFERENCE INPUT |  |  |  |  |  |
| RI DAC Input Range | 2.85/3.15 | 2.85/3.15 | 2.85/3.15 | V min/V max | $3 \mathrm{~V} \pm 5 \%$ |
| Input Current | 1 | 1 |  | $\mu \mathrm{A}$ max |  |
| LOGIC INPUTS |  |  |  |  |  |
| (LDAC, TFS, TCLK, DT) |  |  |  |  |  |
| Input High Voltage, $\mathrm{V}_{\text {INH }}$ | 2.4 | 2.4 | 2.4 | V min | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \%$ |
| Input Low Voltage, $\mathrm{V}_{\text {INL }}$ | 0.8 | 0.8 | 0.8 | V max | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \%$ |
| Input Current, $\mathrm{I}_{\text {IN }}$ | $\pm 10$ | $\pm 10$ | $\pm 10$ | $\mu \mathrm{A}$ max | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}$ |
| Input Capacitance, $\mathrm{C}_{\mathrm{IN}}{ }^{7}$ | 10 | 10 | 10 | pF max |  |
| ANALOG OUTPUT |  |  |  |  |  |
| Output Voltage Range | $\pm 3$ | $\pm 3$ | $\pm 3$ | V nom |  |
| dc Output Impedance | 0.3 | 0.3 | 0.3 | $\Omega$ typ |  |
| Short-Circuit Current | 20 | 20 | 20 | mA typ | - ${ }_{\text {a }}$ |
| AC CHARACTERISTICS ${ }^{7}$ |  |  |  |  |  |
| Voltage Output Settling-Time |  |  |  |  | Setting Time to Within $\pm 1 / 2$ LSB of Final Value |
| Positive Full-Scale Change | 3 | 3 | 3 | $\mu s$ max | Typically $2 \mu \mathrm{~s}$ |
| Negative Full-Scale Change | 3 | 3 | 3 | $\mu \mathrm{s}$ max | Typically $2.5 \mu \mathrm{~s}$ |
| Digital-to-Analog Glitch Impulse | 10 | 10 | 10 | nV secs typ | DAC Code Change All 1 s to All 0 s |
| Digital Feedthrough | 2 | 2 | 2 | nV secs typ |  |
| $\mathrm{V}_{\text {IN }}$ to $\mathrm{V}_{\text {OUT }}$ Isolation | 100 | 100 | 100 | dB typ | $\mathrm{V}_{\mathrm{IN}}= \pm 3 \mathrm{~V}, 41.5 \mathrm{kHz}$ Sine Wave |
| POWER REQUIREMENTS | As per ADC Section |  |  |  |  |

## NOTES

${ }^{1}$ Temperature ranges are as follows: $\mathrm{A} / \mathrm{B}$ Versions, $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; T Version, $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
${ }^{2} \mathrm{~V}_{\text {OUT }}(\mathrm{pk}-\mathrm{pk})= \pm 3 \mathrm{~V}$.
${ }^{3}$ SNR calculation includes distortion and noise components.
${ }^{4}$ Using external sample and hold.
${ }^{5}$ Measured with respect to RI DAC and includes bipolar offset error.
${ }^{6}$ For capacitive loads greater than 50 pF a series resistor is required (see INTER-
NAL REFERENCE section).
${ }^{7}$ Sample tested @ $+25^{\circ} \mathrm{C}$ to ensure compliance.
Specifications subject to notice without notice.

## ORDERING GUIDE

| Model | Temperature <br> Range | Signal- <br> to-Noise <br> Ratio | Relative <br> Accuracy | Package <br> Option |
| :--- | :--- | :--- | :--- | :--- |
| AD7868AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 70 dB | $\pm 1 / 2$ LSB typ | $\mathrm{N}-24$ |
| AD7868AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 70 dB | $\pm 1 / 2 \mathrm{LSB}$ typ | $\mathrm{Q}-24$ |
| AD7868BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 72 dB | $\pm 1$ LSB max | $\mathrm{N}-24$ |
| AD7868BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 72 dB | $\pm 1$ LSB $\max$ | $\mathrm{Q}-24$ |
| AD7868AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 70 dB | $\pm 1 / 2$ LSB typ | $\mathrm{R}-28$ |
| AD7868BR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 72 dB | $\pm 1$ LSB max | $\mathrm{R}-28$ |

[^75]TIMING CHARACTERISTICS ${ }^{1,2}$
$\left(V_{D D}=+5 V \pm 5 \%, V_{S S}=-5 V \pm 5 \%\right.$, AGND $\left.=\operatorname{DGND}=0 \mathrm{~V}\right)$

| Parameter | Limit at $\mathrm{T}_{\text {min }}, \mathrm{T}_{\text {max }}$ (A, B Versions) | Limit at $T_{\text {min }}, T_{\text {max }}$ (T Version) | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: |
| ADC TIMING |  |  |  |  |
| $\mathrm{t}_{1}$ | 50 | 50 | ns min | CONVST Pulse Width |
| $\mathrm{t}_{2}{ }^{3}$ | 440 | 440 | ns min | RCLK Cycle Time, Internal Clock |
| $\mathrm{t}_{3}$ | 100 | 100 | ns min | $\overline{\mathrm{RFS}}$ to RCLK Falling Edge Setup Time |
| $\mathrm{t}_{4}$ | 20 | 20 | ns min | RCLK Rising Edge to RFS |
|  | 100 | 100 | ns max |  |
| $\mathrm{t}_{5}{ }^{4}$ | 155 | 155 | ns max | RCLK to Valid Data Delay, $\mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}$ |
| $t_{6}$ | 4 | 4 | ns min | Bus Relinquish Time after RCLK |
|  | 100 | 100 | ns max |  |
| $\mathrm{t}_{13}{ }^{5}$ | $\begin{aligned} & 2 \text { RCLK }+200 \text { to } \\ & 3 \text { RCLK }+200 \end{aligned}$ | $\begin{aligned} & 2 \text { RCLK + } 200 \text { to } \\ & 3 \text { RCLK }+200 \end{aligned}$ | ns typ | $\overline{\text { CONVST }}$ to $\overline{\mathrm{RFS}}$ Delay |
| DAC TIMING |  |  |  |  |
| $\mathrm{t}_{7}$ | 50 | 50 | ns min | $\overline{\mathrm{TFS}}$ to TCLK Falling Edge |
| $\mathrm{t}_{8}$ | 75 | 100 | ns min | TCLK Falling Edge to TFS |
| $\mathrm{t}_{9}{ }^{6}$ | 150 | 200 | ns min | TCLK Cycle Time |
| $\mathrm{t}_{10}$ | 30 | 40 | ns min | Data Valid to TCLK Setup Time |
| $\mathrm{t}_{11}$ | 75 | 100 | ns min | Data Valid to TCLK Hold Time |
| $\mathrm{t}_{12}$ | 40 | 40 | ns min | $\overline{\text { LDAC }}$ Pulse Width |

## NOTES

${ }^{1}$ Timing specifications are sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance. All input signals are specified with $\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of 5 V$)$ and timed from a voltage level of 1.6 V .
${ }^{2}$ Serial timing is measured with a $4.7 \mathrm{k} \Omega$ pull-up resistor on DR and $\overline{\mathrm{RFS}}$ and a $2 \mathrm{k} \Omega$ pull-up resistor on RCLK. The capacitance on all three outputs is 35 pF .
${ }^{3}$ When using internal clock, RCLK mark/space ratio (measured form a voltage level of 1.6 V ) range is $40 / 60$ to $60 / 40$. For external clock, RCLK mark/space ratio $=$ external clock mark/space ratio.
${ }^{4} \mathrm{DR}$ will drive higher capacitance loads but this will add to $\mathrm{t}_{5}$ since it increases the external RC time constant ( $4.7 \mathrm{k} \Omega / / \mathrm{C}_{\mathrm{L}}$ ) and hence the time to reach 2.4 V .
${ }^{5}$ Time 2 RCLK to 3 RCLK depends on conversion start to ADC clock synchronization.
${ }^{6}$ TCLK mark/space ratio is $40 / 60$ to $60 / 40$.

## ABSOLUTE MAXIMUM RATINGS*

( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)
$\mathrm{V}_{\mathrm{DD}}$ to AGND . . . . . . . . . . . . . . . . . . . -0.3 V to +7 V
V ${ }_{\text {ss }}$ to AGND . . . . . . . . . . . . . . . . . . . . . +0.3 V to -7 V
AGND to DGND . . . . . . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
$\mathrm{V}_{\text {OUt }}$ to AGND . . . . . . . . . . . . . . . . . . . . . . . $\mathrm{V}_{\text {SS }}$ to $\mathrm{V}_{\mathrm{DD}}$
$\mathrm{V}_{\text {IN }}$ to AGND . . . . . . . . . . . . . $\mathrm{V}_{\text {ss }}-0.3 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
RO ADC to AGND . . . . . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
RO DAC to AGND . . . . . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
RI DAC to AGND . . . . . . . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Digital Inputs to DGND . . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Digital Outputs to DGND . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Operating Temperature Range
A, B Versions . . . . . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
T Version . . . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 secs) . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Power Dissipation (Any Package) to $+75^{\circ} \mathrm{C}$. . . . . . 450 mW
Derates above $+75^{\circ} \mathrm{C}$ by . . . . . . . . . . . . . . . . . $10 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## PIN CONFIGURATIONS



NC $=$ NO CONNECT

## CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are inserted.

Complete 14-Bit I/O System, Comprising 14-Bit ADC with Track/Hold Amplifier 83 kHz Throughput Rate 14-Bit DAC with Output Amplifier $3.5 \mu$ s Settling Time On-Chip Voltage Reference<br>Operates from $\pm 5$ V Supplies<br>Low Power - 130 mW typ<br>Small 0.3" Wide DIP<br>APPLICATIONS<br>Digital Signal Processing<br>Speech Recognition and Synthesis<br>Spectrum Analysis<br>High Speed Modems<br>DSP Servo Control

## GENERAL DESCRIPTION

The AD7869 is a complete 14 -bit I/O system containing a DAC and an ADC. The ADC is a successive approximation type with a track-and-hold amplifier having a combined throughput rate of 83 kHz . The DAC has an output buffer amplifier with a settling time of $4 \mu \mathrm{~s}$ to 14 bits. Temperature compensated 3 V buried Zener references provide precision references for the DAC and ADC.
Interfacing to both the DAC and ADC is serial, minimizing pin count and giving a small 24 -pin package size. Standard control signals allow serial interfacing to most DSP machines.
Asynchronous ADC conversion control and DAC updating is made possible with the $\overline{\text { CONVST }}$ and $\overline{\text { LDAC }}$ logic inputs.
The AD7869 operates form $\pm 5 \mathrm{~V}$ power supplies, the analog input/output range of the $\mathrm{ADC} / \mathrm{DAC}$ is $\pm 3 \mathrm{~V}$. The part is fully specified for dynamic parameters such as signal-to-noise ratio and harmonic distortion as well as traditional dc specifications.
The part is available in a 24 -pin, 0.3 inch wide, plastic or hermetic dual-in-line package (DIP) and in a 28 -pin, plastic SOIC package.

PIN CONFIGURATIONS


FUNCTIONAL BLOCK DIAGRAM


## PRODUCT HIGHLIGHTS

1. Complete 14-Bit I/O System.

The AD7869 contains a 14 -bit ADC with a track-and-hold amplifier and a 14 -bit DAC with output amplifier. Also included are separate on-chip voltage references for the DAC and the ADC.
2. Dynamic Specifications for DSP Users.

In addition to traditional dc specifications, the AD7869 is specified for ac parameters including signal-to-noise ratio and harmonic distortion. These parameters along with important timing parameters are tested on every device.
3. Small Package.

The AD7869 is available in a 24 -pin DIP and a 28 -pin SOIC package.

ADC SECTION ${ }^{\left(V_{D 0}=+5 V \pm 5 \%, V_{s s}=-5 V \pm 5 \%, ~ A G N D=D G N D ~\right.}=0 \mathrm{~V}, \mathrm{f}_{\mathrm{CLL}}=2.0 \mathrm{MHz}$ external.
ADC SECIION All specifications $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ unless otherwise noted.)

| Parameter | J Version ${ }^{1}$ | A Version ${ }^{1}$ | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: |
| DYNAMIC PERFORMANCE ${ }^{2}$ <br> Signal-to-Noise Ratio ${ }^{3,4}$ (SNR) @ $+25^{\circ} \mathrm{C}$ $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ <br> Total Harmonic Distortion (THD) <br> Peak Harmonic or Spurious Noise <br> Intermodulation Distortion (IMD) <br> Second Order Terms <br> Third Order Terms <br> Track/Hold Acquisition Time | $\begin{aligned} & 78 \\ & 78 \\ & -86 \\ & -86 \\ & \\ & -86 \\ & -88 \\ & 2 \end{aligned}$ | $\begin{aligned} & 78 \\ & 77 \\ & -86 \\ & -86 \\ & \\ & -86 \\ & -88 \\ & 2 \end{aligned}$ | dB min dB min dB typ dB typ <br> dB typ dB typ $\mu \mathrm{s}$ max | $\begin{aligned} & \mathrm{V}_{\text {IN }}=10 \mathrm{kHz} \text { Sine Wave, } \mathrm{f}_{\text {SAMPLE }}=83 \mathrm{kHz} \\ & \mathrm{~V}_{\text {IN }}=10 \mathrm{kHz} \text { Sine Wave, } \mathrm{f}_{\text {SAMPLE }}=83 \mathrm{kHz} \\ & \mathrm{~V}_{\text {IN }}=10 \mathrm{kHz} \text { Sine Wave, } \mathrm{f}_{\text {SAMPLE }}=83 \mathrm{kHz} \\ & \mathrm{fa}=9 \mathrm{kHz}, \mathrm{fb}=9.5 \mathrm{kHz}, \mathrm{f}_{\text {SAMPLE }}=50 \mathrm{kHz} \\ & \mathrm{fa}=9 \mathrm{kHz}, \mathrm{fb}=9.5 \mathrm{kHz}, \mathrm{f}_{\text {SAMPLE }}=50 \mathrm{kHz} \end{aligned}$ |
| $\overline{D C}$ ACCURACY <br> Resolution <br> Minimum Resolution for Which <br> No Missing Codes Are Guaranteed <br> Integral Nonlinearity <br> Differential Nonlinearity <br> Bipolar Zero Error <br> Positive Gain Error ${ }^{5}$ <br> Negative Gain Error ${ }^{5}$ | 14 <br> 14 <br> $\pm 2$ <br> $\pm 1$ <br> $\pm 20$ <br> $\pm 20$ <br> $\pm 20$ | $\begin{aligned} & 14 \\ & 14 \\ & \pm 2 \\ & \pm 1 \\ & \pm 20 \\ & \pm 20 \\ & \pm 20 \end{aligned}$ | Bits <br> Bits <br> LSB max <br> LSB max <br> LSB max <br> LSB max <br> LSB max |  |
| ANALOG INPUT Input Voltage Range Input Current | $\begin{aligned} & \pm 3 \\ & \pm 1 \end{aligned}$ | $\begin{aligned} & \pm 3 \\ & \pm 1 \end{aligned}$ | Volts mA max |  |
| REFERENCE OUTPUT ${ }^{6}$ <br> RO ADC @ $+25^{\circ} \mathrm{C}$ <br> RO ADC TC <br> Reference Load Sensitivity ( $\Delta$ RO ADC vs. $\Delta \mathrm{I}$ ) | $\begin{aligned} & 2.99 / 3.01 \\ & \pm 25 \\ & \\ & -1.5 \end{aligned}$ | $\begin{aligned} & 2.99 / 3.01 \\ & \pm 25 \\ & \pm 40 \\ & -1.5 \end{aligned}$ | V min/ V max $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ typ $\pm \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ max $m V$ max | Reference Load Current Change (0-500 $\mu \mathrm{A}$ ), Reference Load Should Not Be Changed During Conversion |
| LOGIC INPUTS (CONVST, CLK, CONTROL) Input High Voltage, $\mathrm{V}_{\text {INH }}$ Input Low Voltage, $\mathrm{V}_{\text {INL }}$ Input Current, $\mathrm{I}_{\mathrm{IN}}$ Input Current ${ }^{7}$ (CONTROL \& CLK) Input Capacitance, $\mathrm{C}_{\mathrm{IN}}{ }^{8}$ | $\begin{aligned} & 2.4 \\ & 0.8 \\ & \pm 10 \\ & \pm 10 \\ & 10 \end{aligned}$ | $\begin{aligned} & 2.4 \\ & 0.8 \\ & \pm 10 \\ & \pm 10 \\ & 10 \end{aligned}$ | V min <br> V max <br> $\mu \mathrm{A}$ max <br> $\mu \mathrm{A}$ max <br> pF max | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \% \\ & \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \% \\ & \mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{DD}} \\ & \mathrm{~V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{sS}} \text { to } \mathrm{DGND} \end{aligned}$ |
| LOGIC OUTPUTS <br> DR, $\overline{\text { RFS }}$ Outputs <br> Output Low Voltage, $\mathrm{V}_{\mathrm{OL}}$ <br> RCLK Output <br> Output Low Voltage, $\mathrm{V}_{\mathrm{OL}}$ <br> DR, $\overline{\text { RFS }}$, RCLK Outputs <br> Floating-State Leakage Current <br> Floating-State Output Capacitance ${ }^{8}$ | $\begin{aligned} & 0.4 \\ & 0.4 \\ & \pm 10 \\ & 15 \end{aligned}$ | $\begin{aligned} & 0.4 \\ & 0.4 \\ & \pm 10 \\ & 15 \end{aligned}$ | V max <br> V max <br> $\mu \mathrm{A}$ max pF max | $\begin{aligned} & \mathrm{I}_{\mathrm{SINK}}=1.6 \mathrm{~mA}, \text { Pull-Up Resistor }=4.7 \mathrm{k} \Omega \\ & \mathrm{I}_{\mathrm{SINK}}=2.6 \mathrm{~mA}, \text { Pull-Up Resistor }=2 \mathrm{k} \Omega \end{aligned}$ |
| CONVERSION TIME <br> External Clock <br> Internal Clock | $\begin{aligned} & 10 \\ & 10 \end{aligned}$ | $\begin{aligned} & 10 \\ & 10 \end{aligned}$ | $\mu \mathrm{s}$ max $\mu \mathrm{S}$ max | The Internal Clock Has a Nominal Value of 2.0 MHz |
| POWER REQUIREMENTS $\mathbf{V}_{\mathrm{DD}}$ $\mathbf{V}_{\mathrm{ss}}$ $\mathrm{I}_{\mathrm{DD}}$ $\mathrm{I}_{\mathrm{SS}}$ Total Power Dissipation | $\begin{aligned} & +5 \\ & -5 \\ & 22 \\ & 12 \\ & 170 \end{aligned}$ | $\begin{aligned} & +5 \\ & -5 \\ & 22 \\ & 12 \\ & 170 \end{aligned}$ | V nom V nom mA max mA max mW max | For Both DAC and ADC <br> $\pm 5 \%$ for Specified Performance <br> $\pm 5 \%$ for Specified Performance <br> Cumulative Current from the Two $\mathrm{V}_{\mathrm{DD}}$ Pins Cumulative Current from the Two $\mathrm{V}_{\text {Ss }}$ Pins Typically 130 mW |

[^76] ure 2, $\mathrm{V}_{\text {OUT }}$ Load to $A G N D_{;}=2 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}$. All specifications $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ unless otherwise noted.)

| Parameter | J Version ${ }^{1}$ | A Version ${ }^{1}$ | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: |
| DYNAMIC PERFORMANCE ${ }^{2}$ <br> Signal-to-Noise Ratio ${ }^{3}$ (SNR) @ $+25^{\circ} \mathrm{C}$ $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ <br> Total Harmonic Distortion (THD) <br> Peak Harmonic or Spurious Noise | $\begin{aligned} & 78 \\ & 78 \\ & -86 \\ & -86 \end{aligned}$ | $\begin{aligned} & 78 \\ & 77 \\ & -86 \\ & \\ & -86 \end{aligned}$ | dB min dB min dB typ dB typ | $\mathrm{V}_{\text {OUT }}=1 \mathrm{kHz}$ Sine Wave, $\mathrm{f}_{\text {SAMPLE }}=83 \mathrm{kHz}$ <br> Typically 82 dB at $+25^{\circ} \mathrm{C}$ for $0<\mathrm{V}_{\text {OuT }}<20 \mathrm{kHz}^{4}$ <br> $\mathrm{V}_{\text {OUT }}=1 \mathrm{kHz}$ Sine Wave, $\mathrm{f}_{\text {SAMPLE }}=83 \mathrm{kHz}$ <br> Typically -84 dB at $+25^{\circ} \mathrm{C}$ for $0<\mathrm{V}_{\text {OUT }}<20 \mathrm{kHz}^{4}$ <br> $\mathrm{V}_{\text {OUT }}=1 \mathrm{kHz}, \mathrm{f}_{\text {SAMPLE }}=83 \mathrm{kHz}$ <br> Typically -84 dB at $+25^{\circ} \mathrm{C}$ for $0<\mathrm{V}_{\text {OUT }}<20 \mathrm{kHz}^{4}$ |
| DC ACCURACY <br> Resolution Integral Nonlinearity Differential Nonlinearity Bipolar Zero Error Positive Full-Scale Error ${ }^{5}$ Negative Full-Scale Error ${ }^{5}$ | $\begin{aligned} & 14 \\ & \pm 2 \\ & \pm 1 \\ & \pm 10 \\ & \pm 10 \\ & \pm 10 \end{aligned}$ | $\begin{aligned} & 14 \\ & \pm 2 \\ & \pm 1 \\ & \pm 10 \\ & \pm 10 \\ & \pm 10 \end{aligned}$ | Bits <br> LSB max <br> LSB max <br> LSB max <br> LSB max <br> LSB max | Guaranteed Monotonic |
| REFERENCE OUTPUT ${ }^{6}$ <br> RO DAC @ $+25^{\circ} \mathrm{C}$ <br> RO DAC TC <br> Reference Load Change ( $\Delta$ RO DAC vs. $\Delta \mathrm{I}$ ) | $\begin{aligned} & 2.99 / 3.01 \\ & \pm 25 \\ & -1.5 \end{aligned}$ | $\begin{aligned} & 2.99 / 3.01 \\ & \pm 25 \\ & \pm 40 \\ & \\ & -1.5 \end{aligned}$ | $\mathrm{V} \min / \mathrm{V} \max$ $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ typ $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ max mV max | Reference Load Current Change (0-500 $\mu \mathrm{A}$ ) |
| REFERENCE INPUT RI DAC Input Range Input Current | $\begin{aligned} & 2.85 / 3.15 \\ & 1 \end{aligned}$ | $\begin{aligned} & 2.85 / 3.15 \\ & 1 \end{aligned}$ | $\begin{aligned} & V \min / V \max \\ & \mu \mathrm{~A} \max \end{aligned}$ | $3 \mathrm{~V} \pm 5 \%$ |
| LOGIC INPUTS <br> ( $\overline{\mathrm{LDAC}}, \mathrm{TFS}, \mathrm{TCLK}, \mathrm{DT}$ ) Input High Voltage, $\mathrm{V}_{\text {INH }}$ Input Low Voltage, $\mathrm{V}_{\text {INL }}$ Input Current, $\mathrm{I}_{\mathrm{IN}}$ Input Capacitance, $\mathrm{C}_{\mathrm{IN}}{ }^{7}$ | $\begin{aligned} & 2.4 \\ & 0.8 \\ & \pm 10 \\ & 10 \end{aligned}$ | $\begin{aligned} & 2.4 \\ & 0.8 \\ & \pm 10 \\ & 10 \end{aligned}$ | V min V max $\mu \mathrm{A}$ max pF max | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \% \\ & \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \% \\ & \mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{DD}} \end{aligned}$ |
| ANALOG OUTPUT Output Voltage Range DC Output Impedance Short-Circuit Current | $\begin{aligned} & \pm 3 \\ & 0.3 \\ & 20 \end{aligned}$ | $\begin{aligned} & \pm 3 \\ & 0.3 \\ & 20 \end{aligned}$ | V nom $\Omega$ typ mA typ |  |
| AC CHARACTERISTICS ${ }^{7}$ <br> Voltage Output Settling-Time Positive Full-Scale Change Negative Full-Scale Change Digital-to-Analog Glitch Impulse Digital Feedthrough $\mathrm{V}_{\text {IN }}$ to $\mathrm{V}_{\text {OUT }}$ Isolation | $\begin{array}{\|l} 4 \\ 4 \\ 10 \\ 2 \\ 100 \end{array}$ | $\begin{array}{\|l} \hline 4 \\ 4 \\ 10 \\ 2 \\ 100 \end{array}$ | Ms max <br> $\mu \mathrm{s}$ max <br> nV secs typ <br> nV secs typ <br> dB typ | Settling Time to Within $\pm 1 / 2$ LSB of Final Value <br> Typically $3 \mu \mathrm{~s}$ <br> Typically $3.5 \mu \mathrm{~s}$ <br> DAC Code Change All is to All Os <br> $\mathrm{V}_{\mathrm{IN}}= \pm 3 \mathrm{~V}, 41.5 \mathrm{kHz}$ Sine Wave |
| POWER REQUIREMENTS | As per ADC Section |  |  |  |

## NOTES

${ }^{1}$ Temperature ranges are as follows: J Version, $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$; A Version, $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.
${ }^{2} V_{\text {OUT }}(p-p)= \pm 3 \mathrm{~V}$.
${ }^{3}$ SNR calculation includes distortion and noise components.
${ }^{4}$ Using external sample and hold, see Figures 13 to 15.
${ }^{5}$ Measured with respect to REF IN and includes bipolar offset error.
${ }^{6}$ For capacitive loads greater than 50 pF a series resistor is required (see Internal Reference section).
${ }^{7}$ Sample tested @ $+25^{\circ} \mathrm{C}$ to ensure compliance.
Specifications subject to change without notice.

| Parameter | Limit at $\mathbf{T}_{\text {min }}, \mathbf{T}_{\text {max }}$ (All Versions) | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: |
| ADC TIMING |  |  |  |
| $\mathrm{t}_{1}$ | 50 | ns min | CONVST Pulse Width |
| $\mathrm{t}_{2}{ }^{3}$ | 440 | ns min | RCLK Cycle Time, Internal Clock |
| $\mathrm{t}_{3}$ | 100 | ns min | $\overline{\mathrm{RFS}}$ to RCLK Falling Edge Setup Time |
| $\mathrm{t}_{4}$ | 20 | ns min | RCLK Rising Edge to $\overline{\mathrm{RFS}}$ |
|  | 100 | ns max |  |
| $\mathrm{t}_{5}{ }^{4}$ | 155 | ns max | RCLK to Valid Data Delay, $\mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}$ |
| $t_{6}$ | 4 | ns min | Bus Relinquish Time after RCLK |
|  | 100 | ns max |  |
| $t_{13}{ }^{5}$ | $\begin{aligned} & 2 \text { RCLK }+200 \text { to } \\ & 3 \text { RCLK }+200 \end{aligned}$ | ns typ | $\overline{\text { CONVST }}$ to $\overline{\mathrm{RFS}}$ Delay |
| DAC TIMING |  |  |  |
| $\mathrm{t}_{7}$ | 50 | ns min | $\overline{\mathrm{TFS}}$ to TCLK Falling Edge |
| $\mathrm{t}_{8}$ | 75 | ns min | TCLK Falling Edge to TFS |
| $\mathrm{t}_{9}{ }^{6}$ | 150 | ns min | TCLK Cycle Time |
| $\mathrm{t}_{10}$ | 30 | ns min | Data Valid to TCLK Setup Time |
| $\mathrm{t}_{11}$ | 75 | ns min | Data Valid to TCLK Hold Time |
| $\mathrm{t}_{12}$ | 40 | ns min | $\overline{\text { LDAC Pulse Width }}$ |

NOTES
${ }^{1}$ Timing specifications are sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance. All input signals are specified with $\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of 5 V$)$ and timed from a voltage level of 1.6 V .
${ }^{2}$ Serial timing is measured with a $4.7 \mathrm{k} \Omega$ pull-up resistor on DR and $\overline{\mathrm{RFS}}$ and a $2 \mathrm{k} \Omega$ pull-up resistor on RCLK. The capacitance on all three outputs is 35 pF .
${ }^{3}$ When using internal clock, RCLK mark/space ratio (measured form a voltage level of 1.6 V ) range is $40 / 60$ to $60 / 40$. For external clock, RCLK mark/space ratio $=$ external clock mark/space ratio.
${ }^{4} \mathrm{DR}$ will drive higher capacitance loads but this will add to $\mathrm{t}_{5}$ since it increases the external RC time constant $\left(4.7 \mathrm{k} \Omega / / \mathrm{C}_{\mathrm{L}}\right)$ and hence the time to reach 2.4 V .
${ }^{5}$ Time 2 RCLK to 3 RCLK depends on conversion start to ADC clock synchronization.
${ }^{6}$ TCLK mark/space ratio is $40 / 60$ to $60 / 40$.

## ABSOLUTE MAXIMUM RATINGS*

( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)
$\mathrm{V}_{\mathrm{DD}}$ to AGND . . . . . . . . . . . . . . . . . . . -0.3 V to +7 V
$\mathrm{V}_{\text {ss }}$ to AGND . . . . . . . . . . . . . . . . . . . . +0.3 V to -7 V
AGND to DGND . . . . . . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
V $_{\text {OUT }}$ to AGND . . . . . . . . . . . . . . . . . . . . . . . V V $_{\text {SS }}$ to $\mathrm{V}_{\text {DD }}$
$\mathrm{V}_{\text {IN }}$ to AGND . . . . . . . . . . . . . $\mathrm{V}_{\text {Ss }}-0.3 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
RO ADC to AGND . . . . . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
RO DAC to AGND . . . . . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
RI DAC to AGND . . . . . . . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Digital Inputs to DGND . . . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Digital Outputs to DGND . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$

Operating Temperature Range
J Version . . . . . . . . . . . . . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
A Version . . . . . . . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 secs) . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Power Dissipation (Any Package) to $+75^{\circ} \mathrm{C}$. . . . . . . 1000 mW
Derates above $+75^{\circ} \mathrm{C}$ by . . . . . . . . . . . . . . . . $10 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are inserted.


ORDERING GUIDE

| Model | Temperature <br> Range | Signal- <br> to-Noise <br> Ratio (SNR) | Relative <br> Accuracy | Package <br> Option |
| :--- | :--- | :--- | :--- | :--- |
| AD7869JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 78 dB | $\pm 2$ LSB max | $\mathrm{N}-24$ |
| AD7869JR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 78 dB | $\pm 2$ LSB max | R-28 |
| AD7869AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 77 dB | $\pm 2$ LSB max | $\mathrm{Q}-24$ |

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## FEATURES

Fast 12-Bit ADC with $5.9 \mu$ s Conversion Time
Eight Single-Ended Analog Input Channels
Selection of Input Ranges
$\pm 10 \mathrm{~V}$ for AD7890-10
0 V to +4.096 V for AD7890-4
0 V to +2.5 V for AD7890-2
Allows Separate Access to Multiplexer and ADC
On-Chip Track/Hold Amplifier
On-Chip Reference
High Speed, Flexible, Serial Interface
Single Supply, Low Power Operation ( 50 mW max)
Power-Down Mode ( $75 \mu \mathrm{~W}$ typ)

## GENERAL DESCRIPTION

The AD7890 is an eight-channel 12 -bit data acquisition system. The part contains an input multiplexer, an on-chip track/hold amplifier, a high-speed 12 -bit ADC, a +2.5 V reference and a high speed, serial interface. The part operates from a single +5 V supply and accepts an analog input range of $\pm 10 \mathrm{~V}$ (AD7890-10), 0 to +4.096 V (AD7890-4) and 0 to +2.5 V (AD7890-2).
The multiplexer on the part is independently accessible. This allows the user to insert an antialiasing filter or signal conditioning, if required, between the multiplexer and the ADC. This means that one antialiasing filter can be used for all eight channels. Connection of an external capacitor allows the user to adjust the time given to the multiplexer settling to include any external delays in the filter or signal conditioning circuitry.
Output data from the AD7890 is provided via a high speed bidirectional serial interface port. The part contains an on-chip control register, allowing control of channel selection, conversion start and power-down via the serial port. Versatile, high speed logic ensures easy interfacing to serial ports on microcontrollers and digital signal processors.
In addition to the traditional de accuracy specifications such as linearity, full-scale and offset errors, the AD7890 is also specified for dynamic performance parameters including harmonic distortion and signal-to-noise ratio.

## FUNCTIONAL BLOCK DIAGRAM


*NO SCALING ON AD7890-2
Power dissipation in normal mode is low at 30 mW typ and the part can be placed in a standby (power-down) mode if it is not required to perform conversions. The AD7890 is fabricated in Analog Devices' Linear Compatible CMOS (LC ${ }^{2}$ MOS) process, a mixed technology process that combines precision bipolar circuits with low power CMOS logic. The part is available in a 24 -pin, $0.3^{\prime \prime}$ wide, plastic or hermetic dual-in-line package or in a 24 -pin small outline package (SOIC).

## PRODUCT HIGHLIGHTS

1. Complete 12-Bit Data Acquisition System on a Chip The AD7890 is a complete monolithic ADC combining an eight-channel multiplexer, 12-bit ADC, +2.5 V reference and a track/hold amplifier on a single chip.
2. Separate Access to Multiplexer and ADC

The AD7890 provides access to the output of the multiplexer allowing one antialiasing filter for eight channels-a considerable saving over the eight antialiasing filters required if the multiplexer was internally connected to the ADC.
3. High Speed Serial Interface

The part provides a high speed serial interface for easy connection to serial ports of microcontrollers and DSP processors.

[^78]AD7890
external, MUX OUT connect to SHA IN. All specifications $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ unless otherwise noted.)

| Parameter | A Versions ${ }^{1}$ | B Versions | S Version | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DYNAMIC PERFORMANCE <br> Signal to (Noise + Distortion) Ratio ${ }^{2}$ Total Harmonic Distortion (THD) ${ }^{2}$ Peak Harmonic or Spurious Noise ${ }^{2}$ Intermodulation Distortion 2nd Order Terms 3rd Order Terms Channel-to-Channel Isolation ${ }^{2}$ | $\left\lvert\, \begin{aligned} & 70 \\ & -78 \\ & -79 \\ & \\ & -80 \\ & -80 \\ & -80 \end{aligned}\right.$ | $\left\lvert\, \begin{aligned} & 70 \\ & -78 \\ & -79 \\ & \\ & -80 \\ & -80 \\ & -80 \end{aligned}\right.$ | $\left\lvert\, \begin{aligned} & 70 \\ & -78 \\ & -79 \\ & \\ & -80 \\ & -80 \\ & -80 \end{aligned}\right.$ | dB min dB max dB max dB typ dB typ dB max | Using External $\overline{\text { CONVST. Any Channel }}$ $\mathrm{f}_{\mathrm{IN}}=10 \mathrm{kHz}$ Sine Wave, $\mathrm{f}_{\text {SAMPLE }}=100 \mathrm{kHz}^{3}$ <br> $\mathrm{f}_{\mathrm{IN}}=10 \mathrm{kHz}$ Sine Wave, $\mathrm{f}_{\text {SAMPLE }}=100 \mathrm{kHz}^{3}$ <br> $\mathrm{f}_{\mathrm{IN}}=10 \mathrm{kHz}$ Sine Wave, $\mathrm{f}_{\text {SAMPLE }}=100 \mathrm{kHz}^{3}$ <br> $\mathrm{fa}=9 \mathrm{kHz}, \mathrm{fb}=9.5 \mathrm{kHz}, \mathrm{f}_{\text {SAMPLE }}=100 \mathrm{kHz}^{3}$ <br> $\mathrm{f}_{\mathrm{IN}}=1 \mathrm{kHz}$ Sine Wave |
| DC ACCURACY <br> Resolution Minimum Resolution for Which <br> No Missing Codes are Guaranteed <br> Relative Accuracy ${ }^{2}$ <br> Differential Nonlinearity ${ }^{2}$ <br> Positive Full-Scale Error ${ }^{2}$ <br> Full-Scale Error Match ${ }^{4}$ <br> AD7890-2, AD7890-4 <br> Unipolar Offset Error ${ }^{2}$ <br> Unipolar Offset Error Match <br> AD7890-10 Only <br> Negative Full-Scale Error ${ }^{2}$ <br> Bipolar Zero Error ${ }^{2}$ <br> Bipolar Zero Error Match | $\begin{aligned} & 12 \\ & 12 \\ & \pm 1 \\ & \pm 1 \\ & \pm 2.5 \\ & 2 \\ & \pm 2 \\ & 2 \\ & \\ & \pm 2 \\ & \pm 4 \\ & 2 \end{aligned}$ | $\begin{aligned} & 12 \\ & 12 \\ & \pm 0.5 \\ & \pm 1 \\ & \pm 2.5 \\ & 2 \\ & \pm 2 \\ & 2 \\ & \\ & \pm 2 \\ & \pm 4 \\ & 2 \end{aligned}$ | $\begin{aligned} & 12 \\ & 12 \\ & \pm 1 \\ & \pm 1 \\ & \pm 2.5 \\ & 2 \\ & \pm 2 \\ & \pm 2 \\ & \\ & \pm 2 \\ & \pm 4 \\ & 2 \end{aligned}$ | Bits <br> Bits <br> LSB max <br> LSB max <br> LSB max <br> LSB max <br> LSB max <br> LSB max <br> LSB max <br> LSB max <br> LSB max | Any Channel |
| ANALOG INPUTS <br> AD7890-10 <br> Input Voltage Range <br> Input Resistance <br> AD7890-4 <br> Input Voltage Range <br> Input Resistance <br> AD7890-2 <br> Input Voltage Range Input Current | $\begin{aligned} & \pm 10 \\ & 20 \\ & 0 \text { to }+4.096 \\ & 11 \\ & 0 \text { to }+2.5 \\ & 50 \end{aligned}$ | $\begin{aligned} & \pm 10 \\ & 20 \\ & 0 \text { to }+4.096 \\ & 11 \\ & 0 \text { to }+2.5 \\ & 50 \end{aligned}$ | $\begin{aligned} & \pm 10 \\ & 20 \\ & 0 \text { to }+4.096 \\ & 11 \\ & 0 \text { to }+2.5 \\ & 200 \end{aligned}$ | Volts $k \Omega$ min <br> Volts $\mathrm{k} \Omega$ min <br> Volts nA max |  |
| MUX OUT OUTPUT <br> Output Voltage Range Output Resistance (AD7890-10, AD7890-4) (AD7890-2) | $\begin{aligned} & 0 \text { to }+2.5 \\ & 3 / 5 \\ & 2 \end{aligned}$ | $\begin{aligned} & 0 \text { to }+2.5 \\ & 3 / 5 \\ & 2 \end{aligned}$ | $\begin{aligned} & 0 \text { to }+2.5 \\ & 3 / 5 \\ & 2 \end{aligned}$ | Volts <br> $\mathrm{k} \Omega$ min $/ \mathrm{k} \Omega$ max $\mathrm{k} \Omega$ max | Assuming $\mathrm{V}_{\text {IN }}$ Is Driven from Low Impedance |
| SHA IN INPUT Input Voltage Range Input Current | $\begin{aligned} & 0 \text { to }+2.5 \\ & \pm 50 \end{aligned}$ | $\begin{aligned} & 0 \text { to }+2.5 \\ & \pm 50 \end{aligned}$ | $\begin{aligned} & 0 \text { to }+2.5 \\ & \pm 50 \end{aligned}$ | Volts nA max |  |
| REFERENCE OUTPUT/INPUT <br> REF IN Input Voltage Range <br> Input Impedance <br> Input Capacitance ${ }^{5}$ <br> REF OUT Output Voltage <br> REF OUT Error @ $+25^{\circ} \mathrm{C}$ <br> $\mathrm{T}_{\mathrm{MIN}}$ to $\mathrm{T}_{\mathrm{MAX}}$ <br> REF OUT Temperature Coefficient <br> REF OUT Output Impedance | $\begin{aligned} & 2.375 / 2.625 \\ & 1.6 \\ & 10 \\ & 2.5 \\ & \pm 10 \\ & \pm 20 \\ & 25 \\ & 2 \end{aligned}$ | $\begin{aligned} & 2.375 / 2.625 \\ & 1.6 \\ & 10 \\ & 2.5 \\ & \pm 10 \\ & \pm 20 \\ & 25 \\ & 2 \end{aligned}$ | $\begin{aligned} & 2.375 / 2.625 \\ & 1.6 \\ & 10 \\ & 2.5 \\ & \pm 10 \\ & \pm 25 \\ & 25 \\ & 2 \end{aligned}$ | $\mathrm{V} \min / \mathrm{V} \max$ $\mathrm{k} \Omega$ min pF max V nom mV max mV max $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ typ $\mathrm{k} \Omega$ nom | $2.5 \mathrm{~V} \pm 5 \%$ <br> Resistor Connected to Internal Reference Node |
| LOGIC INPUTS <br> Input High Voltage, $\mathrm{V}_{\text {INH }}$ Input Low Voltage, $\mathrm{V}_{\text {INL }}$ Input Current, $\mathrm{I}_{\text {IN }}$ Input Capacitance, $\mathrm{C}_{\mathrm{IN}}{ }^{5}$ | $\begin{array}{\|l} 2.4 \\ 0.8 \\ \pm 10 \\ 10 \end{array}$ | $\begin{array}{\|l} 2.4 \\ 0.8 \\ \pm 10 \\ 10 \end{array}$ | $\begin{aligned} & 2.4 \\ & 0.8 \\ & \pm 10 \\ & 10 \end{aligned}$ | $V$ min V max $\mu \mathrm{A}$ max pF max | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \% \\ & \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \% \\ & \mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{DD}} \end{aligned}$ |


| Parameter | A Versions ${ }^{1}$ | B Versions | S Version | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| LOGIC OUTPUTS Output High Voltage, $\mathrm{V}_{\mathrm{OH}}$ Output Low Voltage, $\mathrm{V}_{\mathrm{OL}}$ Serial Data Output Coding AD7890-10 AD7890-4 AD7890-2 | $\left\lvert\, \begin{array}{lll} 4.0 & \\ 0.4 & \\ & & \\ & & 2 \mathrm{~s} \\ & & \text { Straigh } \\ & \text { Straigh } \end{array}\right.$ | $\begin{aligned} & \text { 4.0 } \\ & 0.4 \\ & \text { 2s Complemen } \\ & \text { ht (Natural) E } \\ & \text { ht (Natural) E } \end{aligned}$ | 4.0 0.4 Binary Binary | $\begin{aligned} & V_{\min } \\ & V_{\max } \end{aligned}$ | $\begin{aligned} & I_{\text {SOURCE }}=200 \mu \mathrm{~A} \\ & I_{\text {SINK }}=1.6 \mathrm{~mA} \end{aligned}$ |
| CONVERSION RATE <br> Conversion Time <br> Track/Hold Acquisition Time ${ }^{2,5}$ | $\begin{array}{\|l\|} 5.9 \\ 2 \end{array}$ | $\begin{aligned} & 5.9 \\ & 2 \end{aligned}$ | $\begin{aligned} & 5.9 \\ & 2 \end{aligned}$ | $\left\lvert\, \begin{aligned} & \mu s \max \\ & \mu s \max \end{aligned}\right.$ | $\mathrm{f}_{\text {CLK IN }}=2.5 \mathrm{MHz}, \mathrm{MUX}$ OUT Connected to SHA IN |
| POWER REQUIREMENTS <br> $V_{D D}$ <br> $\mathrm{I}_{\mathrm{DD}}$ (Normal Mode) <br> $\mathrm{I}_{\mathrm{DD}}$ (Standby Mode) ${ }^{6} @+25^{\circ} \mathrm{C}$ <br> Power Dissipation <br> Normal Mode <br> Standby Mode @ $+25^{\circ} \mathrm{C}$ | $\begin{aligned} & +5 \\ & 10 \\ & 15 \\ & \\ & 50 \\ & 75 \end{aligned}$ | $\begin{aligned} & +5 \\ & 10 \\ & 15 \\ & \\ & 50 \\ & 75 \end{aligned}$ | $\begin{aligned} & +5 \\ & 10 \\ & 15 \\ & 50 \\ & 75 \\ & \hline \end{aligned}$ | V nom mA max $\mu \mathrm{A}$ typ <br> mW max $\mu \mathrm{W}$ typ | $\pm 5 \%$ for Specified Performance <br> Logic Inputs $=0 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{DD}}$ <br> Logic Inputs $=0 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{DD}}$ <br> Typically 30 mW |

NOTES
${ }^{1}$ Temperature ranges are as follows: A, B Versions: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; S Version: $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
${ }^{2}$ See Terminology.
${ }^{3}$ This sample rate is only achievable when using the part in external clocking mode.
${ }^{4}$ Full-scale error match applies to positive full scale for the AD7890-2 and AD7890-4. It applies to both positive and negative full scale for the AD7890-10.
${ }^{5}$ Sample tested @ $+25^{\circ} \mathrm{C}$ to ensure compliance.
${ }^{6}$ Analog inputs on AD7890-10 must be at 0 V to achieve correct power-down current.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS*

( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)
$\mathrm{V}_{\mathrm{DD}}$ to AGND . . . . . . . . . . . . . . . . . . . -0.3 V to +7 V
$\mathrm{V}_{\mathrm{DD}}$ to DGND . . . . . . . . . . . . . . . . . . -0.3 V to +7 V
Analog Input Voltage to AGND
AD7890-10, AD7890-4 . . . . . . . . . . . . . . . . . . . . $\pm 17$ V
AD7890-2 . . . . . . . . . . . . . . . . . . . . . . . . $-5 \mathrm{~V},+10 \mathrm{~V}$
Reference Input Voltage to AGND . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Digital Input Voltage to DGND . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Digital Output Voltage to DGND . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Operating Temperature Range
Commercial (A, B Versions) . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Extended (S Version) . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Junction Temperature . . . . . . . . . . . . . . . . . . . . . . $+150^{\circ} \mathrm{C}$
Plastic DIP Package, Power Dissipation . . . . . . . . . . 450 mW
$\theta_{\mathrm{JA}}$ Thermal Impedance . . . . . . . . . . . . . . . . . . $105^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature (Soldering, 10 sec ) . . . . . . . . . $+260^{\circ} \mathrm{C}$
Cerdip Package, Power Dissipation . . . . . . . . . . . . . 450 mW $\theta_{\mathrm{JA}}$ Thermal Impedance . . . . . . . . . . . . . . . . . . . $70^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature (Soldering, 10 sec ) . . . . . . . . . $+300^{\circ} \mathrm{C}$
SOIC Package, Power Dissipation . . . . . . . . . . . . . . 450 mW $\theta_{\mathrm{JA}}$ Thermal Impedance . . . . . . . . . . . . . . . . . . . $75^{\circ} \mathrm{C} / \mathrm{W}$ Lead Temperature, Soldering

Vapor Phase (60 sec) . . . . . . . . . . . . . . . . . . . . $+215^{\circ} \mathrm{C}$
Infrared (15 sec) . . . . . . . . . . . . . . . . . . . . . . $+220^{\circ} \mathrm{C}$
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ORDERING GUIDE

| Model | Temperature <br> Range | Linearity <br> Error (LSB) | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD7890AN-2 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ | $\mathrm{N}-24$ |
| AD7890BN-2 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1 / 2 \mathrm{LSB}$ | $\mathrm{N}-24$ |
| AD7890AR-2 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ | $\mathrm{R}-24$ |
| AD7890BR-2 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1 / 2 \mathrm{LSB}$ | $\mathrm{R}-24$ |
| AD7890SQ-2 | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ | $\mathrm{Q}-24$ |
| AD7890AN-4 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ | $\mathrm{N}-24$ |
| AD7890BN-4 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1 / 2 \mathrm{LSB}$ | $\mathrm{N}-24$ |
| AD7890AR-4 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ | $\mathrm{R}-24$ |
| AD7890BR-4 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1 / 2 \mathrm{LSB}$ | $\mathrm{R}-24$ |
| AD7890SQ-4 | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ | $\mathrm{Q}-24$ |
| AD7890AN-10 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ | $\mathrm{N}-24$ |
| AD7890BN-10 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1 / 2 \mathrm{LSB}$ | $\mathrm{N}-24$ |
| AD7890AR-10 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ | $\mathrm{R}-24$ |
| AD7890BR-10 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 1 / 2 \mathrm{LSB}$ | $\mathrm{R}-24$ |
| AD7890SQ-10 | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\pm 1 \mathrm{LSB}$ | $\mathrm{Q}-24$ |

${ }^{\star} N=$ Plastic DIP; $\mathbf{Q}=$ Cerdip; $\mathrm{R}=$ SOIC. For outline information see Package Information section.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD7890 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

$$
\text { TIMING CHARACTERISTICS }{ }^{1,2} \begin{aligned}
& \left(\begin{array}{l}
\left(V_{D D}=+5 \mathrm{~V} \pm 5 \%\right. \\
\text { MUX OUT connected to } \operatorname{SHA} \operatorname{IN} .)
\end{array}\right.
\end{aligned}
$$

| Parameter | Limit at $\mathbf{T}_{\text {min }}, \mathbf{T}_{\text {max }}$ (A, B, S Versions) | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: |
| $\mathrm{f}_{\text {CLKIN }}{ }^{3}$ | 100 | kHz min | Master Clock Frequency. For Specified Performance |
|  | 2.5 | MHz max |  |
| $\mathrm{t}_{\text {CLK IN LO }}$ | $0.3 \times \mathrm{t}_{\text {CLK }} \mathrm{IN}$ | ns min | Master Clock Input Low Time |
| $\mathrm{t}_{\text {CLK IN }}{ }^{\text {Hi }}$ | $0.3 \times \mathrm{t}_{\text {CLK }} \mathrm{IN}$ | ns min | Master Clock Input High Time |
|  | 25 | ns max | Digital Output Rise Time. Typically 10 ns |
| $\mathrm{tf}^{4}$ | 25 | ns max | Digital Output Fall Time. Typically 10 ns |
| $\mathrm{t}_{\text {Convert }}$ | 5.9 | $\mu \mathrm{s}$ max | Conversion Time |
| ${ }_{\text {cest }}$ | 100 | $n \mathrm{nmin}$ | CONVST Pulse Width |
| Self-Clocking Mode |  |  |  |
| $\mathrm{t}_{1}$ | $\mathrm{t}_{\text {CLK IN HI }}+50$ | ns max | $\overline{\text { RFS }}$ Low to SCLK Falling Edge |
| $\mathrm{t}_{2}{ }^{5}$ | 25 | ns max | $\overline{\mathrm{RFS}}$ Low to Data Valid Delay |
| $\mathrm{t}_{3}$ | $\mathrm{t}_{\text {CLK IN HI }}$ | ns nom | SCLK High Pulse Width |
| $\mathrm{t}_{4}$ | $\mathrm{t}_{\text {ClK in lo }}$ | ns nom | SCLK Low Pulse Width |
| $t_{5}{ }^{5}$ | 20 | ns max | SCLK Rising Edge to Data Valid Delay |
| $\mathrm{t}_{6}$ | 40 | ns max | SCLK Rising Edge to $\overline{\mathrm{RFS}}$ Delay |
| $t_{7}{ }^{6}$ | 50 | ns max | Bus Relinquish Time after Rising Edge of SCLK |
| $\mathrm{t}_{8}$ | 0 | ns min | TFS Low to SCLK Falling Edge |
|  | $\mathrm{t}_{\text {CLK IN }}+50$ | ns max |  |
| $\mathrm{t}_{9}$ | 0 | ns min | Data Valid to TFS Falling Edge Setup Time (A2 Address Bit) |
| $\mathrm{t}_{10}$ | 20 | ns min | Data Valid to SCLK Falling Edge Setup Time |
| $t_{11}$ | 10 | ns min | Data Valid to SCLK Falling Edge Hold Time |
| $\mathrm{t}_{12}$ | 20 | ns min | TFS to SCLK Falling Edge Hold Time |
| External-Clocking Mode |  |  |  |
| $\mathrm{t}_{13}$ | 20 | ns min | $\overline{\text { RFS }}$ Low to SCLK Falling Edge Setup Time |
| $\mathrm{t}_{14}{ }^{5}$ | 40 | ns max | $\overline{\text { RFS }}$ Low to Data Valid Delay |
| $\mathrm{t}_{15}$ | 50 | ns min | SCLK High Pulse Width |
| $\mathrm{t}_{16}{ }_{5}$ | 50 | ns min | SCLK Low Pulse Width |
| $\mathrm{t}_{17}{ }^{5}$ | 35 | ns max | SCLK Rising Edge to Data Valid Delay |
| $\mathrm{t}_{18}$ | 20 | ns min | $\overline{\text { RFS }}$ to SCLK Falling Edge Hold Time |
| $\mathrm{t}_{19}{ }^{6}$ | 50 | ns max | Bus Relinquish Time after Rising Edge of $\overline{\text { RFS }}$ |
| $\mathrm{t}_{19 \mathrm{~A}}{ }^{6}$ | 90 | ns max | Bus Relinquish Time after Rising Edge of SCLK |
| $\mathrm{t}_{20}$ | 20 | ns min | TFS Low to SCLK Falling Edge Setup Time |
| $\mathrm{t}_{21}$ | 10 | ns min | Data Valid to SCLK Falling Edge Setup Time |
| $\mathrm{t}_{22}$ | 15 | ns min | Data Valid to SCLK Falling Edge Hold Time |
| $\mathrm{t}_{23}$ | 40 | ns min | $\overline{T F S}$ to SCLK Falling Edge Hold Time |

NOTES
${ }^{1}$ Sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance. All input signals are specified with $\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of 5 V$)$ and timed from a voltage level of 1.6 V .
${ }^{2}$ See Figures 8 to 11.
${ }^{3}$ The AD7890 is production tested with $\mathrm{f}_{\text {CLKIN }}$ at 2.5 MHz . It is guaranteed by characterization to operate at 100 kHz .
${ }^{4}$ Specified using $10 \%$ and $90 \%$ points on waveform of interest.
${ }^{5}$ These numbers are measured with the load circuit of Figure 1 and defined as the time required for the output to cross 0.8 V or 2.4 V .
${ }^{6}$ These numbers are derived from the measured time taken by the data output to change 0.5 V when loaded with the circuit of Figure 1 . The measured number is then extrapolated back to remove effects of charging or discharging the 50 pF capacitor. This means that the times quoted in the timing characteristics are the true bus relinquish times of the part and as such are independent of external bus loading capacitances.


Figure 1. Load Circuit for Access Time and Bus Relinquish Time

| Pin | Mnemonic | Description |
| :---: | :---: | :---: |
| 1 | AGND | Analog Ground. Ground reference for track/hold, comparator and DAC. |
| 2 | SMODE | Control Input. Determines whether the part operates in its External Clocking (slave) or Self-Clocking (master) serial mode. With SMODE at a logic low, the part is in its Self-Clocking serial mode with $\overline{\mathrm{RFS}}$ and SCLK as outputs. This Self-Clocking mode is useful for connection to shift registers or to serial ports of DSP processors. With SMODE at a logic high, the part is in its External Clocking serial mode with SCLK and $\overline{\mathrm{RFS}}$ as inputs. This External Clocking mode is useful for connection to the serial port of microcontrollers such as the 8 XC 51 and the 68 HCXX and for connection to the serial ports of DSP processors. |
| 3 | DGND | Digital Ground. Ground reference for digital circuitry. |
| 4 | $\mathrm{C}_{\text {Ext }}$ | External Capacitor. An external capacitor is connected to this pin to determine the length of the internal pulse (see CONVST input and Control Register section). Larger capacitances on this pin extend the pulse to allow for settling time delays through an external antialiasing filter or signal conditioning circuitry. |
| 5 | CONVST | Convert Start. Edge-triggered logic input. A low to high transition on this input puts the track/hold into hold and initiates conversion provided that the internal pulse has timed out (see Control Register section). If the internal pulse is active when the CONVST goes high, the track/hold will not go into hold until the pulse times out. If the internal pulse has timed out when CONVST goes high, the rising edge of CONVST drives the track/hold into hold and initiates conversion. |
| 6 | CLK IN | Clock Input. An external TTL-compatible clock is applied to this input pin to provide the clock source for the conversion sequence. In the Self-Clocking serial mode, the SCLK output is derived from this CLK IN pin. |
| 7 | SCLK | Serial Clock Input. In the External Clocking (slave) mode (see Serial Interface section) this is an externally applied serial clock which is used to load serial data to the control register and to access data from the output register. In the Self-Clocking (master) mode, the internal serial clock, which is derived from the clock input (CLK IN), appears on this pin. Once again, it is used to load serial data to the control register and to access data from the output register. |
| 8 | $\overline{\mathrm{TFS}}$ | Transmit Frame Synchronization Pulse. Active low logic input with serial data expected after the falling edge of this signal. |
| 9 | $\overline{\mathrm{RFS}}$ | Receive Frame Synchronization Pulse. In the External Clocking mode, this pin is an active low logic input with $\overline{\mathrm{RFS}}$ provided externally as a strobe or framing pulse to access serial data from the output register. In the Self-Clocking mode, it is an active low output which is internally generated and provides a strobe or framing pulse for serial data from the output register. For applications which require that data be transmitted and received at the same time, $\overline{\mathrm{RFS}}$ and $\overline{\mathrm{TFS}}$ should be connected together. |
| 10 | DATA OUT | Serial Data Output. Sixteen bits of serial data are provided with one leading zero, preceding the three address bits of the Control register and the 12 bits of conversion data. Serial data is valid on the falling edge of SCLK for sixteen edges after RFS goes low. Output coding from the ADC is 2 s complement for the AD7890-10 and straight binary for the AD7890-4 and AD7890-2. |
| 11 | DATA IN | Serial Data Input. Serial data to be loaded to the control register is provided at this input. The first five bits of serial data are loaded to the control register on the first five falling edges of SCLK after $\overline{T F S}$ goes low. Serial data on subsequent SCLK edges is ignored while TFS remains low. |
| 12 | $\mathrm{V}_{\mathrm{DD}}$ | Positive supply voltage, $+5 \mathrm{~V} \pm 5 \%$. |
| 13 | MUX OUT | Multiplexer Output. The output of the multiplexer appears at this pin. The output voltage range from this output is 0 V to +2.5 V for the nominal analog input range to the selected channel. The output impedance of this output is nominally $3.5 \mathrm{k} \Omega$. If no external antialiasing filter is required, MUX OUT should be connected to SHA IN. |
| 14 | SHA IN | Track/Hold Input. The input to the on-chip track/hold is applied to this pin. It is a high impedance input and the input voltage range is 0 V to +2.5 V . |
| 15 | AGND | Analog Ground. Ground reference for track/hold, comparator and DAC. |
| 16 | $\mathrm{V}_{\mathrm{IN} 1}$ | Analog Input Channel 1. Single-ended analog input. The analog input range on is $\pm 10 \mathrm{~V}$ (AD7890-10), 0 V to +4.096 V (AD7890-4) and 0 V to +2.5 V (AD7890-2). The channel to be converted is selected using the A0, A1 and A2 bits in the control register. The multiplexer has guaranteed break-before-make operation. |


| Pin | Mnemonic | Description |
| :---: | :---: | :---: |
| 17 | $\mathrm{V}_{\mathrm{IN} 2}$ | Analog Input Channel 2. Single-ended analog input. The analog input range on is $\pm 10 \mathrm{~V}$ (AD7890-10), 0 V to +4.096 V (AD7890-4) and 0 V to +2.5 V (AD7890-2). The channel to be converted is selected using the $\mathrm{A} 0, \mathrm{Al}$ and A 2 bits in the control register. The multiplexer has guaranteed break-before-make operation. |
| 18 | $\mathrm{V}_{\mathrm{IN} 3}$ | Analog Input Channel 3. Single-ended analog input. The analog input range on is $\pm 10 \mathrm{~V}$ (AD7890$10), 0 \mathrm{~V}$ to +4.096 V (AD7890-4) and 0 V to +2.5 V (AD7890-2). The channel to be converted is selected using the A0, A1 and A2 bits in the control-register. The multiplexer has guaranteed break-before-make operation. |
| 19 | $\mathrm{V}_{\text {IN } 4}$ | Analog Input Channel 4. Single-ended analog input. The analog input range on is $\pm 10 \mathrm{~V}$ (AD789010 ), 0 V to +4.096 V (AD7890-4) and 0 V to +2.5 V (AD7890-2). The channel to be converted is selected using the A0, A1 and A2 bits in the control register. The multiplexer has guaranteed break-before-make operation. |
| 20 | $\mathrm{V}_{\text {INS }}$ | Analog Input Channel 5. Single-ended analog input. The analog input range on is $\pm 10 \mathrm{~V}$ (AD789010 ), 0 V to +4.096 V (AD7890-4) and 0 V to +2.5 V (AD7890-2). The channel to be converted is selected using the A0, A1 and A2 bits in the control register. The multiplexer has guaranteed break-before-make operation. |
| 21 | $\mathrm{V}_{\mathrm{IN} 6}$ | Analog Input Channel 6. Single-ended analog input. The analog input range on is $\pm 10$ V(AD7890$10), 0 \mathrm{~V}$ to +4.096 V (AD7890-4) and 0 V to +2.5 V (AD7890-2). The channel to be converted is selected using the A0, A1 and A2 bits in the control register. The multiplexer has guaranteed break-before-make operation. |
| 22 | $\mathrm{V}_{\text {IN } 7}$ | Analog Input Channel 7. Single-ended analog input. The analog input range on is $\pm 10 \mathrm{~V}$ (AD7890$10), 0 \mathrm{~V}$ to +4.096 V (AD7890-4) and 0 V to +2.5 V (AD7890-2). The channel to be converted is selected using the A0, A1 and A2 bits in the control register. The multiplexer has guaranteed break-before-make operation. |
| 23 | $\mathrm{V}_{\text {IN8 }}$ | Analog Input Channel 8. Single-ended analog input. The analog input range on is $\pm 10 \mathrm{~V}$ (AD7890$10), 0 \mathrm{~V}$ to $+4.096 \mathrm{~V}(\mathrm{AD} 7890-4)$ and 0 V to +2.5 V (AD7890-2). The channel to be converted is selected using the A0, A1 and A2 bits in the control register. The multiplexer has guaranteed break-before-make operation. |
| 24 | REF OUT/REF IN | Voltage Reference Output/Input. The part can be used with either its own internal reference or with an external reference source. The on-chip +2.5 V reference voltage is provided at this pin. When using this internal reference as the reference source for the part, REF OUT should decoupled to AGND with a $0.1 \mu \mathrm{~F}$ disc ceramic capacitor. The output impedance of this reference source is typically $2 \mathrm{k} \Omega$. When using an external reference source as the reference voltage for the part, the reference source should be connected to this pin. This overdrives the internal reference and provides the reference source for the part. The REF IN input is buffered on-chip. The nominal reference voltage for correct operation of the AD7890 is +2.5 V . |

PIN CONFIGURATION
DIP and SOIC


## AD7890

## TERMINOLOGY

## Signal to (Noise + Distortion) Ratio

This is the measured ratio of signal to (noise + distortion) at the output of the A/D converter. The signal is the rms amplitude of the fundamental. Noise is the rms sum of all nonfundamental signals up to half the sampling frequency ( $\mathrm{f}_{\mathrm{s}} / 2$ ), excluding dc. The ratio is dependent upon the number of quantization levels in the digitization process; the more levels, the smaller the quantization noise. The theoretical signal to (noise + distortion) ratio for an ideal N -bit converter with a sine wave input is given by:

$$
\text { Signal to }(\text { Noise }+ \text { Distortion })=(6.02 N+1.76) d B
$$

Thus for a 12-bit converter, this is 74 dB .

## Total Harmonic Distortion

Total harmonic distortion (THD) is the ratio of the rms sum of harmonics to the fundamental. For the AD7890, it is defined as:

$$
T H D(d B)=20 \log \frac{\sqrt{V_{2}^{2}+V_{3}^{2}+V_{4}^{2}+V_{5}^{2}+V_{6}^{2}}}{V_{1}}
$$

where $V_{1}$ is the rms amplitude of the fundamental and $V_{2}, V_{3}$, $V_{4}, V_{5}$ and $V_{6}$ are the rms amplitudes of the second through the sixth harmonics.

## Peak Harmonic or Spurious Noise

Peak harmonic or spurious noise is defined as the ratio of the rms value of the next largest component in the ADC output spectrum (up to $\mathrm{f}_{\mathrm{s}} / 2$ and excluding dc) to the rms value of the fundamental. Normally, the value of this specification is determined by the largest harmonic in the spectrum, but for parts where the harmonics are buried in the noise floor, it will be a noise peak.

## Intermodulation Distortion

With inputs consisting of sine waves at two frequencies, fa and fb , any active device with nonlinearities will create distortion products at sum and difference frequencies of $\mathrm{mfa} \pm \mathrm{nfb}$ where $\mathrm{m}, \mathrm{n}=0,1,2,3$, etc. Intermodulation terms are those for which neither $m$ or $n$ are equal to zero. For example, the second order terms include ( $\mathrm{fa}+\mathrm{fb}$ ) and ( $\mathrm{fa}-\mathrm{fb}$ ), while the third order terms include $(2 f a+f b),(2 f a-f b),(f a+2 f b)$ and $(f a-$ 2 fb ).
The AD7890 is tested using the CCIF standard where two input frequencies near the top end of the input bandwidth are used. In this case, the second and third order terms are of different significance. The second order terms are usually distanced in frequency from the original sine waves while the third order terms are usually at a frequency close to the input frequencies. As a result, the second and third order terms are specified separately. The calculation of the intermodulation distortion is as per the THD specification where it is the ratio of the rms sum of the individual distortion products to the rms amplitude of the fundamental expressed in dBs.

## Channel-to-Channel Isolation

Channel-to-channel isolation is a measure of the level of crosstalk between channels. It is measured by applying a fullscale 1 kHz signal to any one of the other seven inputs and determining how much that signal is attenuated in the channel of interest. The figure given is the worst case across all eight channels.

## Relative Accuracy

Relative accuracy or endpoint nonlinearity is the maximum deviation from a straight line passing through the endpoints of the ADC transfer function.

## Differential Nonlinearity

This is the difference between the measured and the ideal 1 LSB change between any two adjacent codes in the ADC.

## Positive Full-Scale Error (AD7890-10)

This is the deviation of the last code transition ( 01 . . . 110 to $01 \ldots 111$ ) from the ideal ( $4 \times$ REF IN -1 LSB) after the Bipolar Zero Error has been adjusted out.

## Positive Full-Scale Error (AD7890-4)

This is the deviation of the last code transition (11 . . . 110 to 11 . . . 111) from the ideal ( $1.638 \times$ REF IN -1 LSB) after the Unipolar Offset Error has been adjusted out.
Positive Full-Scale Error (AD7890-2)
This is the deviation of the last code transition (11 . . 110 to 11 . . . 111) from the ideal (REF IN - 1 LSB) after the Unipolar Offset Error has been adjusted out.

## Bipolar Zero Error (AD7890-10)

This is the deviation of the midscale transition (all 0 s to all 1 s ) from the ideal 0 V (AGND).

## Unipolar Offset Error (AD7890-2, AD7890-4)

This is the deviation of the first code transition ( $00 \ldots 000$ to 00 . . 001) from the ideal 0 V (AGND).
Negative Full-Scale Error (AD7890-10)
This is the deviation of the first code transition ( $10 \ldots 000$ to 10 . . . 001) from the ideal ( $-4 \times$ REF IN +1 LSB ) after Bipolar Zero Error has been adjusted out.

## Track/Hold Acquisition Time

Track/Hold acquisition time is the time required for the output of the track/hold amplifier to reach its final value, within $\pm 1 / 2$ LSB, after the end of conversion (the point at which the track/hold returns to track mode). It also applies to situations where a change in the selected input channel takes place or where there is a step input change on the input voltage applied to the selected $\mathrm{V}_{\text {IN }}$ input of the AD7890. It means that the user must wait for the duration of the track/hold acquisition time after the end of conversion or after a channel change/step input change to $\mathrm{V}_{\text {IN }}$ before starting another conversion, to ensure that the part operates to specification.

## CONTROL REGISTER

The Control Register for the AD7890 contains 5 bits of information as described below. Six serial clock pulses must be provided to the part in order to write data to the Control Register (seven if the write is required to put the part in Standby Mode). If TFS returns high before six serial clock cycles then no data transfer takes place to the Control Register and the write cycle will have to be restarted to write the data to the Control Register. If, however, the CONV bit of the register (see below) is set to a Logic 1, then a conversion will be initiated whenever a Control Register write takes place regardless of how many serial clock cycles the TFS remains low for. The default (power-on) condition of all bits in the Control Register is 0 .
MSB

| A2 | A1 | A0 | CONV | STBY |
| :--- | :--- | :--- | :--- | :--- |

A2 $\quad$ Address Input. This input is the most significant address input for multiplexer channel selection.
A1 Address Input. This is the 2nd most significant address input for multiplexer channel selection.

Address Input. Least significant address input for multiplexer channel selection. When the address is written to the control register, an internal pulse is initiated, the pulse width of which is determined by the value of capacitance on the $\mathrm{C}_{\text {EXt }}$ pin. When this pulse is active, it ensures the conversion process cannot be activated. This allows for the multiplexer settling time and track/hold acquisition time before the track/hold goes into hold and conversion is initiated. In applications where there is an antialiasing filter between MUX OUT and SHA IN, the filter settling time can be taken into account before the input at SHA IN is sampled. When the internal pulse times out, the track/hold goes into hold and conversion is initiated.
Conversion Start. Writing a 1 to this bit initiates a conversion in a similar manner to the CONVST input. Continuous conversion starts do not take place when there is a 1 in this location. The internal pulse and the conversion process are initiated after the sixth serial clock cycle of the write operation if a 1 is written to this bit. With a 1 in this bit, the hardware conversion start i.e., the CONVST input, is disabled. Writing a 0 to this bit enables the hardware CONVST input.
Standby Mode Input. Writing a 1 to this bit places the device in its standby or power-down mode.
Writing a 0 to this bit places the device in its normal operating mode. The part does not enter its standby mode until the seventh falling edge of SCLK in a write operation. Therefore, the part requires seven serial clock pulses in its serial write operation if it is required to put the part into standby

## CONVERTER DETAILS

The AD7890 is an eight-channel, 12-bit, single supply, serial data acquisition system. It provides the user with signal scaling, multiplexer, track/hold, reference, A/D converter and versatile serial logic functions on a single chip. The signal scaling allows the part to handle $\pm 10 \mathrm{~V}$ input signals (AD7890-10) and 0 V to +4.096 V input signals (AD7890-4) while operating from a single +5 V supply. The AD7890-2 contains no signal scaling and accepts an analog input range of 0 V to +2.5 V . The part operates from $\mathrm{a}+2.5 \mathrm{~V}$ reference which can be provided from the part's own internal reference or from an external reference source.
Unlike other single chip data acquisition solutions, the AD7890 provides the user with separate access to the multiplexer and the A/D converter. This means that the flexibility of separate multiplexer and ADC solutions is not sacrificed with the one-chip solution. With access to the multiplexer output, the user can implement external signal conditioning between the multiplexer and the track/hold. It means that one antialiasing filter can be used on the output of the multiplexer to provide the antialiasing function for all eight channels.
Conversion is initiated on the AD7890 either by pulsing the CONVST input or by writing a Logic 1 to the CONV bit of the Control Register. When using the hardware CONVST input, on the rising edge of the $\overline{\text { CONVST }}$ signal, the on-chip track/hold goes from track to hold mode and the conversion sequence is started provided the internal pulse has timed out. This internal pulse (which appears at the $\mathrm{C}_{\text {EXt }}$ pin) is initiated whenever the multiplexer address is loaded to the AD7890 Control Register. This pulse goes from high to low when a serial write to the part is initiated. It starts to discharge on the sixth falling clock edge of SCLK in a serial write operation to the part. The track/hold cannot go into hold and conversion cannot be initiated until the $\mathrm{C}_{\text {EXt }}$ pin has crossed its trigger point of 2.5 V . The discharge time of the voltage on $\mathrm{C}_{\text {EXT }}$ depends upon the value of capacitor connected to the $\mathrm{C}_{\text {EXt }}$ pin (see $\mathrm{C}_{\text {EXT }}$ Functioning section). The fact that the pulse is initiated every time a write to the control register takes place means that the software conversion start and track/hold signal is always delayed by the internal pulse.
The conversion clock for the part is generated from the clock signal applied to the CLK IN pin of the part. Conversion time for the AD7890 is $5.9 \mu \mathrm{~s}$ from the rising edge of the hardware CONVST signal and the track/hold acquisition time is $2 \mu \mathrm{~s}$. To obtain optimum performance from the part, the data read operation or Control Register write operation should not occur during the conversion or during 500 ns prior to the next conversion. This allows the part to operate at throughput rates up to 117 kHz in the external clocking mode and achieve data sheet specifications. The part can operate at slightly higher throughput rates (up to 127 kHz ), again in external clocking mode with degraded performance (see Timing and Control section). The throughput rate for self clocking mode is limited by the serial clock rate to 78 kHz .
All unused inputs should be connected to a voltage within the nominal analog input range to avoid noise pickup. On the AD7890-10, if any one of the input channels which are not being converted goes more negative than -12 V , it can interfere with the conversion on the selected channel.

## AD7890

## CIRCUIT DESCRIPTION

## Analog Input Section

The AD7890 is offered as three part types, the AD7890-10 which handles a $\pm 10 \mathrm{~V}$ input voltage range, the AD7890-4 which handles a 0 to +4.096 V input range and the AD7890-2 which handles a 0 to +2.5 V input voltage range.

## AD7890-10

Figure 2 shows the analog input section for the AD7890-10. The analog input range for each of the analog inputs is $\pm 10 \mathrm{~V}$ into an input resistance of typically $33 \mathrm{k} \Omega$. This input is benign with no dynamic charging currents with the resistor attenuator stage followed by the multiplexer and in cases where MUX OUT is connected to SHA IN this is followed by the high input impedance stage of the track/hold amplifier. The designed code transitions occur on successive integer LSB values (i.e., 1 LSB, 2 LSBs, 3 LSBs . . . ). Output coding is 2 s complement binary with $1 \mathrm{LSB}=\mathrm{FS} / 4096=20 \mathrm{~V} / 4096=4.88 \mathrm{mV}$. The ideal input/output transfer function is shown in Table I.


Figure 2. AD7890-10 Analog Input Structure

Table I. Ideal Input/Output Code Table for the AD7890-10

| Analog Input ${ }^{1}$ | Digital Output Code Transition |
| :---: | :---: |
| +FSR/2-1 LSB ${ }^{2}$ (9.995117 V) | 011 . . . 110 to 011 . . . 111 |
| +FSR/2 - 2 LSBs (9.990234 V) | 011 . . . 101 to $011 . \ldots 110$ |
| +FSR/2 - 3 LSBs (9.985352 V) | 011 . . . 100 to 011 . . . 101 |
| AGND + 1 LSB (0.004883 V) | 000 . . . 000 to $000 \ldots 001$ |
| AGND ( 0.000000 V ) | 111 . . . 111 to 000 . . . 000 |
| AGND - 1 LSB ( -0.004883 V ) | $111 . . .110$ to $111 . . .111$ |
| -FSR/2 + 3 LSBs (-9.985352 V) | $100 \ldots 010$ to $100 \ldots 011$ |
| -FSR/2 + 2 LSBs (-9.990234 V) | 100 . . . 001 to $100 \ldots 010$ |
| -FSR/2 + 1 LSB (-9.995117 V) | 100 . . 000 to $100 \ldots 001$ |

## NOTES

${ }^{1} \mathrm{FSR}$ is full-scale range and is 20 V with REF IN $=+2.5 \mathrm{~V}$.
${ }^{2} 1 \mathrm{LSB}=\mathrm{FSR} / 4096=4.883 \mathrm{mV}$ with REF $\mathrm{IN}=+2.5 \mathrm{~V}$.

## AD7890-4

Figure 3 shows the analog input section for the AD7890-4. The analog input range for each of the analog inputs is $\pm 10 \mathrm{~V}$ into an input resistance of typically $15 \mathrm{k} \Omega$. This input is benign with no dynamic charging currents with the resistor attenuator stage followed by the multiplexer and in cases where MUX OUT is connected to SHA IN this is followed by the high input impedance stage of the track/hold amplifier. The designed code transitions occur on successive integer LSB values (i.e., 1 LSB,

2 LSBs, 3 LSBs . . . ). Output coding is straight (natural) binary with $1 \mathrm{LSB}=\mathrm{FS} / 4096=4.096 \mathrm{~V} / 4096=1 \mathrm{mV}$. The ideal input/output transfer function is shown in Table II.


Figure 3. AD7890-4 Analog Input Structure
Table II. Ideal Input/Output Code Table for the AD7890-4

| Analog Input ${ }^{1}$ | Digital Output <br> Code Transition |
| :--- | :--- |
| +FSR -1 LSB $^{2}(4.095 \mathrm{~V})$ | $111 \ldots 110$ to $111 \ldots 111$ |
| +FSR -2 LSBs $(4.094 \mathrm{~V})$ | $111 \ldots 101$ to $111 \ldots 110$ |
| +FSR -3 LSBs $(4.093 \mathrm{~V})$ | $111 \ldots 100$ to $111 \ldots 101$ |
| AGND + 3 LSBs $(0.003 \mathrm{~V})$ | $000 \ldots 010$ to $000 \ldots 011$ |
| AGND + 2 LSBs $(0.002 \mathrm{~V})$ | $000 \ldots 001$ to $000 \ldots 010$ |
| AGND + 1 LSB $(0.001 \mathrm{~V})$ | $000 \ldots 000$ to $000 \ldots 001$ |

## NOTES

${ }^{1} \mathrm{FSR}$ is full-scale range and is 4.096 V with REF IN $=+2.5 \mathrm{~V}$. ${ }^{2} 1 \mathrm{LSB}=\mathrm{FSR} / 4096=1 \mathrm{mV}$ with REF IN $=+2.5 \mathrm{~V}$.

## AD7890-2

The analog input section for the AD7890-2 contains no biasing resistors and the selected analog input connects to the multiplexer and in cases where MUX OUT is connected to SHA IN this is followed by the high input impedance stage of the track/ hold amplifier. The analog input range is, therefore, 0 V to +2.5 V into a high impedance stage with an input current of less than 50 nA . The designed code transitions occur on successive integer LSB values (i.e., 1 LSB, 2 LSBs, 3 LSBs . . . FS-1 LSBs). Output coding is straight (natural) binary with 1 LSB $=$ FS/4096 $=$ $2.5 \mathrm{~V} / 4096=0.61 \mathrm{mV}$. The ideal input/output transfer function is shown in Table III.

Table III. Ideal Input/Output Code Table for the AD7890-2

| Analog Input $^{1}$ | Digital Output <br> Code Transition |
| :--- | :--- |
| +FSR - 1 LSB $^{2}(2.499390 \mathrm{~V})$ | $111 \ldots 110$ to $111 \ldots 111$ |
| +FSR -2 LSBs $(2.498779 \mathrm{~V})$ | $111 \ldots 101$ to $111 \ldots 110$ |
| +FSR -3 LSBs $(2.498169 \mathrm{~V})$ | $111 \ldots 100$ to $111 \ldots 101$ |
| AGND + 3 LSBs $(0.001831 \mathrm{~V})$ | $000 \ldots 010$ to $010 \ldots 011$ |
| AGND + 2 LSBs $(0.001221 \mathrm{~V})$ | $000 \ldots 001$ to $001 \ldots 010$ |
| AGND + 1 LSB $(0.000610 \mathrm{~V})$ | $000 \ldots 000$ to $000 \ldots 001$ |

## NOTES

${ }^{1}$ FSR is full-scale range and is 2.5 V with $\mathrm{REF} \mathrm{IN}=+2.5 \mathrm{~V}$.
${ }^{2} 1 \mathrm{LSB}=\mathrm{FSR} / 4096=0.61 \mathrm{mV}$ with REF IN $=+2.5 \mathrm{~V}$.

## Track/Hold Section

The SHA IN input on the AD7890 connects directly to the input stage of the track/hold amplifier. This is a high impedance input with input leakage currents of less than 50 nA . Connecting the MUX OUT pin directly to the SHA IN pin connects the multiplexer output directly to the track/hold amplifier. The input voltage range for this input is 0 to +2.5 V . If external circuitry is connected between MUX OUT and SHA IN, then the user must ensure that the input voltage range to the SHA IN input is 0 to +2.5 V to ensure that the full dynamic range of the converter is utilized.

The track/hold amplifier on the AD7890 allows the ADC to accurately convert an input sine wave of full-scale amplitude to 12-bit accuracy. The input bandwidth of the track/hold is greater than the Nyquist rate of the ADC even when the ADC is operated at its maximum throughput rate of 117 kHz (i.e., the track/hold can handle input frequencies in excess of 58 kHz ).
The track/hold amplifier acquires an input signal to 12 -bit accuracy in less than $2 \mu \mathrm{~s}$. The operation of the track/hold is essentially transparent to the user. The track/hold amplifier goes from its tracking mode to its hold mode at the start of conversion. The start of conversion is the rising edge of CONVST (assuming the internal pulse has timed out) for hardware conversion starts and for software conversion starts is the point where the internal pulse is timed out. The aperture time for the track/hold (i.e., the delay time between the external CONVST signal and the track/hold actually going into hold) is typically 15 ns . For software conversion starts, the time depends on the internal pulse widths. Therefore, for software conversion starts, the sampling instant is not very well defined. For sampling systems which require well defined, equidistant sampling, it may not be possible to achieve optimum performance from the part using the software conversion start. At the end of conversion, the part returns to its tracking mode. The acquisition time of the track/ hold amplifier begins at this point.

## Reference Section

The AD7890 contains a single reference pin, labelled
REF OUT/REF IN, which either provides access to the part's own +2.5 V reference or to which an external +2.5 V reference can be connected to provide the reference source for the part. The part is specified with a +2.5 V reference voltage. Errors in the reference source will result in gain errors in the AD7890's transfer function and will add to the specified full-scale errors on the part. On the AD7893-10, it will also result in an offset error injected in the attenuator stage.
The AD7890 contains an on-chip +2.5 V reference. To use this reference as the reference source for the AD7890, simply connect a $0.1 \mu \mathrm{~F}$ disc ceramic capacitor from the REF OUT/
REF IN pin to AGND. The voltage which appears at this pin is internally buffered before being applied to the ADC. If this reference is required for use external to the AD7890, it should be buffered as the source impedance of this output is $2 \mathrm{k} \Omega$ nominal. The tolerance on the internal reference is $\pm 10 \mathrm{mV}$ at $25^{\circ} \mathrm{C}$ with a typical temperature coefficient of $25 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ and a maximum error over temperature of $\pm 25 \mathrm{mV}$.

If the application requires a reference with a tighter tolerance or the AD7890 needs to be used with a system reference, then the user has the option of connecting an external reference to this REF OUT/REF IN pin. The external reference will effectively overdrive the internal reference and thus provide the reference source for the ADC. The reference input is buffered but has a nominal $2 \mathrm{k} \Omega$ resistor connected to the AD7890's internal reference. Suitable reference sources for the AD7890 include the AD680, AD780 and REF-43 precision +2.5 V references.

## Timing and Control Section

The AD7890 is capable of two interface modes, selected by the SMODE input. The first of these is a self-clocking mode where the part provides the frame sync, serial clock and serial data at the end of conversion. In this mode the serial clock rate is determined by the master clock rate of the part (at CLK IN input). The second mode is an external clocking mode where the user provides the frame sync and serial clock signals to obtain the serial data from the part. In this second mode, the user has control of the serial clock rate up to a maximum of 10 MHz . The two modes are discussed in more detail in the Serial Interface section.
The part also provides hardware and software conversion start features. The former provides a well-defined sampling instant with the track/hold going into hold on the rising edge of the $\overline{\text { CONVST }}$ signal. For the software conversion start, a write to the CONV bit to the Control Register initiates the conversion sequence. However, for the software conversion start an internal pulse has to time out before the input signal is sampled. This pulse, plus the difficult in maintaining exactly equal delays between each software conversion start command, means that the dynamic performance of the AD7890 may have difficulty meeting spec when used in software conversion start mode.
The AD7890 provides separate channel select and conversion start control. This allows the user to optimize the throughput rate of the system. Once the track/hold has gone into hold mode, the input channel can be updated and the input voltage can settle to the new value while the present conversion is in progress.
Assuming the internal pulse has timed out before the CONVST pulse is exercised, the conversion will consist of 14.5 master clock cycles. In the self-clocking mode, the conversion time is defined as the time from the rising edge of CONVST to the falling edge of $\overline{\mathrm{RFS}}$ (i.e., when the device starts to transmit its conversion result). This time includes the 14.5 master clock cycles plus the updating of the output register and delay time in outputting the $\overline{\mathrm{RFS}}$ signal, resulting in a total conversion time of $5.9 \mu \mathrm{~s}$ maximum. Figure 4 shows the conversion timing for the AD7890 when used in the Self-Clocking (Master) Mode with hardware CONVST. The timing diagram assumes that the internal pulse is not active when the CONVST signal goes high. To ensure this, the channel address to be converted should be selected by writing to the Control Register prior to the CONVST pulse. Sufficient setup time should be allowed between the Control Register write and the CONVST to ensure that the internal pulse has timed out. The duration of the internal pulse (and hence the duration of setup time) depends on the value of $\mathrm{C}_{\text {EXT }}$.

(I) SIGNIFIES AN INPUT; (O) SIGNIFIES AN OUTPUT. PULL-UP RESISTOR ON SCLK.

Figure 4. Self-Clocking (Master) Mode Conversion Sequence

When using the device in the External-Clocking Mode, the output register can be read at any time and the most up-to-date conversion result will be obtained. However, reading data from the output register or writing data to the Control Register during conversion or during the 500 ns prior to the next $\overline{\text { CONVST }}$ will result in reduced performance from the part. A read operation to the output register has most effect on performance with the signal-to-noise ratio likely to degrade especially when higher serial clock rates are used while the code flicker from the part will also increase (see AD7890 Performance section).

Figure 5 shows the timing and control sequence required to obtain optimum performance from the part in the external clocking mode. In the sequence shown, conversion is initiated on the rising edge of CONVST and new data is available in the output register of the AD7890 $5.9 \mu \mathrm{~s}$ later. Once the read operation has taken place, a further 500 ns should be allowed before
the next rising edge of CONVST to optimize the settling of the track/hold before the next conversion is initiated. The diagram shows the read operation and the write operation taking place in parallel. On the sixth falling edge of SCLK in the write sequence the internal pulse will be initiated. Assuming MUX OUT is connected to SHA IN, $2 \mu \mathrm{~s}$ are required between this sixth falling edge of SCLK and the rising edge of CONVST to allow for the full acquisition time of the track/hold amplifier. With the serial clock rate at its maximum of 10 MHz , the achievable throughput rate for the part is $5.9 \mu \mathrm{~s}$ (conversion time) plus $0.6 \mu \mathrm{~s}$ (six serial clock pulses before internal pulse is initiated) plus $2 \mu \mathrm{~s}$ (acquisition time). This results in a minimum throughput time of $8.5 \mu \mathrm{~s}$ (equivalent to a throughput rate of 117 kHz ). If the part is operated with a slower serial clock, it will impact the achievable throughput rate for optimum performance.


Figure 5. External Clocking (Slave) Mode Timing Sequence for Optimum Performance


Figure 6. $\overline{\text { CONVST Used as Status Signal in External Clocking Mode }}$

In the Self-Clocking Mode, the AD7890 indicates when conversion is complete by bringing the $\overline{\mathrm{RFS}}$ line low and initiating a serial data transfer. In the external clocking mode, there is no indication of when conversion is complete. In many applications, this will not be a problem as the data can be read from the part during conversion or after conversion. However, applications which want to achieve optimum performance from the AD7890 will have to ensure that the data read does not occur during conversion or during 500 ns prior to the rising edge of CONVST. This can be achieved in either of two ways. The first is to ensure in software that the read operation is not initiated until $5.9 \mu$ s after the rising edge of CONVST. This will only be possible if the software knows when the CONVST command is issued. The second scheme would be to use the CONVST signal as both the conversion start signal and an interrupt signal. The simplest way to do this would be to generate a square wave signal for CONVST with high and low times of $5.9 \mu \mathrm{~s}$ (see Figure 6). Conversion is initiated on the rising edge of CONVST. The falling edge of CONVST occurs $5.9 \mu$ s later and can be used as either an active low or falling edge-triggered interrupt signal to tell the processor to read the data from the AD7890. Provided the read operation is completed 500 ns before the rising edge of CONVST, the AD7890 will operate to specification.
This scheme limits the throughput rate to $11.8 \mu \mathrm{~s}$ minimum. However, depending upon the response time of the microprocessor to the interrupt signal and the time taken by the processor to read the data, this may the fastest which the system could have operated. In any case, the CONVST signal does not have to have a $50: 50$ duty cycle. This can be tailored to optimize the throughput rate of the part for a given system.
Alternatively, the CONVST signal can be used as a normal narrow pulse width. The rising edge of CONVST can be used as an active high or rising edge-triggered interrupt. A software delay of $5.9 \mu$ s can then be implemented before data is read from the part.

## Cext $^{\text {Ext }}$ FUNCTIONING

The $\mathrm{C}_{\text {EXT }}$ input on the AD7890 provides a means of determining how long after a new channel address is written to the part that a conversion can take place. The reason behind this is two-fold. Firstly, when the input channel to the AD7890 is changed, the input voltage on this new channel is likely to be very different from the previous channel voltage. Therefore, the part's track/hold has to acquire the new voltage before an accurate conversion can take place. An internal pulse delays any conversion start command (as well as the signal to send the track/hold into hold) until after this pulse has timed out. The second reason is to allow the user to connect external antialiasing or signal conditioning circuitry between MUX OUT and SHA IN. This external circuitry will introduce extra settling time into the system. The $\mathrm{C}_{\text {EXt }}$ pin provides a means for the user to extend the internal pulse to take this extra settling time into account. Basically, varying the value of the capacitor on the $\mathrm{C}_{\text {EXT }}$ pin varies the duration of the internal pulse. Figure 7 shows the relationship between the value of the $\mathrm{C}_{\text {EXT }}$ capacitor and the internal delay.


Figure 7. Internal Pulse Width vs. $C_{E X T}$

## AD7890

The duration of the internal pulse can be seen on the $\mathrm{C}_{\text {EXt }}$ pin. The $\mathrm{C}_{\text {Ext }}$ pin goes from a low to a high when a serial write to the part is initiated (on the falling edge of $\overline{\mathrm{TFS}}$ ). It starts to discharge on the sixth falling edge of SCLK in the serial write operation. Once the $\mathrm{C}_{\text {EXt }}$ pin has discharged to crossing its nominal trigger point of 2.5 V , the internal pulse is timed out.
The internal pulse is initiated each time a write operation to the Control Register takes place. As a result, the pulse is initiated and the conversion process delayed for all software conversion start commands. For hardware conversion start, it is possible to separate the conversion start command from the internal pulse.
If the multiplexer output (MUX OUT) is connected directly to the track/hold input (SHA IN), then no external settling has to be taken into account by the internal pulse width. In applications where the multiplexer is switched and conversion is not initiated until more than $2 \mu \mathrm{~s}$ after the channel is changed (as is possible with a hardware conversion start), the user does not have to worry about connecting any capacitance to the $\mathrm{C}_{\text {EXT }}$ pin. The $2 \mu \mathrm{~s}$ equates to the track/hold acquisition time of the AD7890. In applications where the multiplexer is switched and conversion is initiated at the same time (such as with a software conversion start), a 120 pF capacitor should be connected to $\mathrm{C}_{\text {EXt }}$ to allow for the acquisition time of the track/hold before conversion is initiated.
If external circuitry is connected between MUX OUT and SHA IN, then the extra settling time introduced by this circuitry will have to be taken into account. In the case where the multiplexer change command and the conversion start command are separated, they need to be separated by greater than the acquisition time of the AD7890 plus the settling time of the external circuitry if the user does not have to worry about the $\mathrm{C}_{\text {EXT }}$ capacitance. In applications where the multiplexer is switched and conversion is initiated at the same time (such as with a software conversion start), the capacitor on $\mathrm{C}_{\text {EXT }}$ needs to allow for the acquisition time of the track/hold plus the settling-time of the external circuitry before conversion is initiated.

## SERIAL INTERFACE

The AD7890's serial communications port provides a flexible arrangement to allow easy interfacing to industry-standard microprocessors, microcontrollers and digital signal processors. A serial read to the AD7890 accesses data from the output register via the DATA OUT line. A serial write to the AD7890 writes data to the Control Register via the DATA IN line.

Two different modes of operation are available, optimized for different types of interface where the AD7890 can act either as master in the system (it provides the serial clock and data framing signal) or acts as slave (an external serial clock and framing signal can be provided to the AD7890). These two modes, labelled Self-Clocking Mode and External Clocking Mode, are discussed in detail in the following sections.

## Self-Clocking Mode

The AD7890 is configured for its Self-Clocking Mode by tying the SMODE pin of the device to a logic low. In this mode, the AD7890 provides the serial clock signal and the serial data framing signal used for the transfer of data from the AD7890. This Self-Clocking Mode can be used with processors which allow an external device to clock their serial port including most digital signal processors.

## Read Operation

Figure 8 shows a timing diagram for reading from the AD7890 in the Self-Clocking mode. At the end of conversion, $\overline{\mathrm{RFS}}$ goes low and the serial clock (SCLK) and serial data (DATA OUT) outputs become active. Sixteen bits of data are transmitted with one leading zero, followed by the three address bits of the Control Register, followed by the 12-bit conversion result starting with the MSB. Serial data is clocked out of the device on the rising edge of SCLK and is valid on the falling edge of SCLK. The $\overline{\mathrm{RFS}}$ output remains low for the duration of the sixteen clock cycles. On the sixteenth rising edge of SCLK, the RFS output is driven high and DATA OUT is disabled.


NOTE
(I) SIGNIFIES AN INPUT; (O) SIGNIFIES AN OUTPUT. PULL-UP RESISTOR ON SCLK.

Figure 8. Self-Clocking (Master) Mode Output Register Read

note
(I) SIGNIFIES AN INPUT; (O) SIGNIFIES AN OUTPUT. PULL-UP RESISTOR ON SCLK.

Figure 9. Self-Clocking (Master) Mode Control Register Write

## Write Operation

Figure 9 shows a write operation to the Control Register of the AD7890. The TFS input is taken low to indicate to the part that a serial write is about to occur. TFS going low initiates the SCLK output and this is used to clock data out of the processors serial port and into the Control Register of the AD7890. The AD7890 Control Register requires only five bits of data. These are loaded on the first five clock cycles of the serial clock with data on all subsequent clock cycles being ignored. However, the part requires six serial clock cycles to load data to the Control Register. Serial data to be written to the AD7890 must be valid on the falling edge of SCLK.

## External-Clocking Mode

The AD7890 is configured for its external-clocking mode by tying the SMODE pin of the device to a logic high. In this mode, SCLK and $\overline{\text { RFS }}$ of the AD7890 are configured as inputs. This external-clocking mode is designed for direct interface to systems which provide a serial clock output which is synchronized to the serial data output including microcontrollers such as the $80 \mathrm{C} 51,87 \mathrm{C} 51,68 \mathrm{HCl} 1$ and 68 HC 05 and most digital signal processors.

## Read Operation

Figure 10 shows the timing diagram for reading from the AD7890 in the external-clocking mode. $\overline{\text { RFS }}$ goes low to access data from the AD7890. The serial clock input does not have to be continuous. The serial data can be accessed in a number of bytes. However, $\overline{\mathrm{RFS}}$ must remain low for the duration of the data transfer operation. Once again, sixteen bits of data are
transmitted with one leading zero, followed by the three address bits in the Control Register, followed by the 12-bit conversion result starting with the MSB. If $\overline{\mathrm{RFS}}$ goes low during the high time of SCLK, the leading zero is clocked out from the falling edge of $\overline{\mathrm{RFS}}$ (as per Figure 10). If $\overline{\mathrm{RFS}}$ goes low during the low time of SCLK, the leading zero is clocked out on the next rising edge of SCLK. This ensures that, regardless of whether $\overline{\text { RFS }}$ goes low during a high time or low time of SCLK, the leading zero is valid on the first falling edge of SCLK after $\overline{\text { RFS }}$ goes low, provided $t_{14}$ and $t_{17}$ are adhered to. Serial data is clocked out of the device on the rising edge of SCLK and is valid on the falling edge of SCLK. At the end of the read operation, the DATA OUT line is three-stated by a rising edge on either the SCLK or $\overline{\mathrm{RFS}}$ inputs, whichever occurs first. If a serial read from the output register is in progress when conversion is complete, the updating of the output register is deferred until the serial data read is complete and $\overline{\text { RFS }}$ returns high.

## Write Operation

Figure 11 shows a write operation to the Control Register of the AD7890. As with the Self-Clocking mode, the TFS input goes low to indicate to the part that a serial write is about to occur. As before, the AD7890 Control Register requires only five bits of data. These are loaded on the first five clock cycles of the serial clock with data on all subsequent clock cycles being ignored. However, the part requires six serial clocks to load data to the Control Register. Serial data to be written to the AD7890 must be valid on the falling edge of SCLK.


NOTE
() SIGNIFIES AN INPUT; (0) SIGNIFIES AN OUTPUT

Figure 10. External Clocking (Slave) Mode Output Register Read


NOTE
(I) SIGNIFIES AN INPUT; (O) SIGNIFIES AN OUTPUT.

Figure 11. External Clocking (Slave) Mode Control Register Write

## SIMPLIFYING THE INTERFACE

To minimize the number of interconnect lines to the AD7890, the user can connect the $\overline{\mathrm{RFS}}$ and TFS lines of the AD7890 together and read and write from the part simultaneously. In this case, new control register data should be provided on the DATA IN line selecting the input channel and possibly providing a conversion start command while the part provides the result from the conversion just completed on the DATA OUT line.
In the self-clocking mode, this means that the part provides all the signals for the serial interface. It does require that the microprocessor has the data to be written to the Control Register available in its output register when the part brings the TFS line low. In the external clocking mode, it means that the user only has to supply a single frame synchronization signal to control both the read and write operations.
Care must be taken with this scheme that the read operation is completed before the next conversion starts if the user wants to obtain optimum performance from the part. In the case of the software conversion start, the conversion command is written to the Control Register on the sixth serial clock edge. However, the read operation continues for another 10 serial clock cycles. To avoid reading during the sampling instant or during conversion, the user should ensure that the internal pulse width is sufficiently long (by choosing $\mathrm{C}_{\mathrm{EXT}}$ ) so that the read operation is completed before the next conversion sequence begins. Failure to do this will result in significantly degraded performance from the part, both in terms of signal-to-noise ratio and dc parameters. In the case of a hardware conversion start, the user should ensure that the delay between the sixth falling edge of the serial clock in the write operation and the next rising edge of $\overline{\mathrm{CON}}-$ $\overline{\mathrm{VST}}$ is greater than the internal pulse width.

## MICROPROCESSOR/MICROCONTROLLER INTERFACE

The AD7890's flexible serial interface allows for easy connection to the serial ports of DSP processors and microcontrollers. Figures 12 through 15 show the AD7890 interfaced to a number of different microcontrollers and DSP processors. In some of the interfaces shown, the AD7890 is configured as the master in the system, providing the serial clock and frame sync for the read operation while in others it acts as a slave with these signals provided by the microprocessor.

## AD7890-8051 Interface

Figure 12 shows an interface between the AD7890 and the 8XC51 microcontroller. The AD7890 is configured for its external clocking mode while the $8 \mathrm{XC51}$ is configured for its Mode 0
serial interface mode. The diagram shown in Figure 12 makes no provisions for monitoring when conversion is complete on the AD7890 (assuming hardware conversion start is used). To monitor the conversion time on the AD7890 a scheme such as outlined previously with CONVST can be used. This can be implemented in two ways. One is to connect the CONVST line to another parallel port bit which is configured as an input. This port bit can then be polled to determine when conversion is complete. An alternative is to use an interrupt driven system in which case the CONVST line should be connected to the INT1 input of the 8XC51.
Since the 8 XC 51 contains only one serial data line, the DATA OUT and DATA IN lines of the AD7890 must be connected together. This means that the 8XC51 cannot communicate with the output register and Control Register of the AD7890 at the same time. The 8XC51 outputs the LSB first in a write operation so care should be taken in arranging the data which is to be transmitted to the AD7890. Similarly, the AD7890 outputs the MSB first during a read operation while the 8XC51 expects the LSB first. Therefore, the data that is to be read into the serial port needs to be rearranged before the correct data word from the AD7890 is available in the microcontroller.
The serial clock rate from the $8 \mathrm{XC51}$ is limited to significantly less than the allowable input serial clock frequency with which the AD7890 can operate. As a result, the time to read data from the part will actually be longer than the conversion time of the part. This means that the AD7890 cannot run at its maximum throughput rate when used with the 8 XC 51 .


Figure 12. AD7890 to 8XC51 Interface

## AD7890-68HC11 Interface

An interface circuit between the AD7890 and the 68 HCll microcontroller is shown in Figure 13. For the interface shown, the AD7890 is configured for its external clocking mode while the 68 HCll 's SPI port is used and the 68 HCll is configured in its single-chip mode. The $68 \mathrm{HCl1}$ is configured in the master mode with its CPOL bit set to a logic zero and its CPHA bit set to a logic one.
As with the previous interface, there are no provisions for monitoring when conversion is complete on the AD7890. To monitor the conversion time on the AD7890 a scheme, such as outlined in the previous interface with CONVST, can be used. This can be implemented in two ways. One is to connect the CONVST line to another parallel port bit which is configured as an input. This port bit can then be polled to determine when conversion is complete. An alternative is to use an interrupt driven system in which case the $\overline{\text { CONVST }}$ line should be connected to the $\overline{\text { IRQ }}$ input of the $68 \mathrm{HCl1}$.


Figure 13. AD7890 to $68 \mathrm{HC11}$ Interface
The serial clock rate from the $68 \mathrm{HCl1}$ is limited to significantly less than the allowable input serial clock frequency with which the AD7890 can operate. As a result, the time to read data from the part will actually be longer than the conversion time of the part. This means that the AD7890 cannot run at its maximum throughput rate when used with the $68 \mathrm{HCl1}$.

## AD7890-ADSP-2101 Interface

An interface circuit between the AD7890 and the ADSP-2101 DSP processor is shown in Figure 14. The AD7890 is configured for its external clocking mode with the ADSP-2101 providing the serial clock and frame synchronization signals. The RFS1 and TFS1 inputs are outputs are configured for active low operation.


Figure 14. AD7890 to ADSP-2101 Interface

In the scheme shown, the maximum serial clock frequency which the ADSP-2101 can provide is 6.25 MHz . This allows the AD7890 to be operated at a sample rate of 111 kHz . If it is desirable to operate the AD7890 at its maximum throughput rate of 117 kHz , an external serial clock of 10 MHz can be provided to drive the serial clock input of both the AD7890 and the ADSP-2101.

To monitor the conversion time on the AD7890 a scheme, such as outlined in previous interfaces with CONVST, can be used. This can be implemented by connecting the CONVST line directly to the IRQ2 input of the ADSP-2101. An alternative to this, where the user does not have to worry about monitoring the conversion status, is to operate the AD7890 in its SelfClocking Mode. In this scheme, the actual interface connections would remain the same as in Figure 14 but now the AD7890 provides the serial clock and receive frame synchronization signals. Using the AD7890 in its Self-Clocking Mode, limits the throughput rate of the system as the serial clock rate is limited to 2.5 MHz .

## AD7890-DSP56000 Interface

Figure 15 shows an interface circuit between the AD7890 and the DSP56000 DSP processor. The AD7890 is configured for its external clocking mode. The DSP56000 is configured for normal mode, synchronous operation with continuous clock. It is also set up for a 16-bit word with SCK and SC2 as outputs. The FSL bit of the DSP56000 should be set to 0 .
The $\overline{\mathrm{RFS}}$ and $\overline{\mathrm{TFS}}$ inputs of the AD7890 are connected together so data is transmitted to and from the AD7890 at the same time. With the DSP56000 in synchronous mode, it provides a common frame synchronization pulse for read and write operations on its SC2 output. This is inverted before being applied to the $\overline{\mathrm{RFS}}$ and $\overline{\mathrm{TFS}}$ inputs of the AD7890.
To monitor the conversion time on the AD7890 a scheme, such as outlined in previous interface examples with CONVST, can be used. This can be implemented by connecting the CONVST line directly to the IRQA input of the DSP56000.


Figure 15. AD7890 to DSP56000 Interface

# LC²MOS 8-Channel, 12-Bit High Speed Data Acquisition System 

## FEATURES

Fast 12-Bit ADC with $1.6 \mu \mathrm{~s}$ Conversion Time Eight Single-Ended Analog Input Channels
Selection of Input Ranges:

## $\pm 5 \mathrm{~V}, \pm 10 \mathrm{~V}$ for AD7891-1

0 V to $+2.5 \mathrm{~V}, 0$ to $+5 \mathrm{~V} \pm 2.5 \mathrm{~V}$ for AD7891-2
Parallel and Serial Interface
Allows Separate Access to Mux and ADC
On-Chip Track/Hold Amplifier On-Chip Reference
Single Supply, Low Power Operation ( 75 mW max)
Power-Down Mode (75 $\mu$ W typ)
Overvoltage Protection on Analog Inputs

## GENERAL DESCRIPTION

The AD7891 is an eight-channel 12-bit data acquisition system with a choice of either parallel or serial interface structure. The part contains an input multiplexer, an on-chip track/hold amplifier, a high speed 12 -bit $\mathrm{ADC}, \mathrm{a}+2.5 \mathrm{~V}$ reference and a high speed interface. The part operates from a single +5 V supply and accepts a variety of analog input ranges across two models, the AD7891-1 ( $\pm 5 \mathrm{~V}$ and $\pm 10 \mathrm{~V}$ ) and the AD7891-2 ( 0 V to $+2.5 \mathrm{~V}, 0 \mathrm{~V}$ to +5 V and $\pm 2.5 \mathrm{~V}$ ).
The multiplexer on the part is independently accessible. As a result, an antialiasing filter or signal conditioning can be inserted, if required, between the multiplexer and the ADC. This allows one antialiasing filter to be used for all eight channels. The value of an external capacitor determines the time given to the multiplexer settling to allow for any external delays in the filter or signal conditioning circuitry.
The AD7891 provides the option of either a parallel interface or serial interface structure determined by the MODE pin. The part has standard control inputs and fast data access times for both the serial and parallel interfaces which ensures easy interfacing to modern microprocessors, microcontrollers and digital signal processors.
In addition to the traditional dc accuracy specifications such as linearity, full-scale and offset errors, the part is also specified for dynamic performance parameters including harmonic distortion and signal-to-noise ratio.

## FUNCTIONAL BLOCK DIAGRAM



Power dissipation in normal mode is 60 mW typical while in the standby mode this is reduced to $75 \mu \mathrm{~W}$ typ. The AD7891 is fabricated in Analog Devices' Linear Compatible CMOS ( $L^{2}$ MOS) process, a mixed technology process that combines precision bipolar circuits with low power CMOS logic. The part is available in a 44 -pin plastic quad flatpack (PQFP) and a 44lead plastic leaded chip carrier (PLCC).

## PRODUCT HIGHLIGHTS

1. The AD7891 is a complete monolithic 12-bit data acquisition system combining an eight-channel multiplexer, 12-bit ADC, +2.5 V reference and track/hold amplifier on a single chip.
2. The part provides separate access to the multiplexer and the ADC, thus retaining all the flexibility of separate multiplexer and $A D C$ solutions.
3. The part offers high speed parallel or serial interface options for easy connection to microprocessors, microcontrollers and digital signal processors.

This is a preliminary data sheet. To obtain the most recent version or
complete data sheet, call our fax retrieval system at 1-800-446-6212.

SDEREFATMNS $\left(V_{D D}=+5 \mathrm{~V}, \mathrm{AGND}=\mathrm{DGND}=0 \mathrm{~V}\right.$, REF IN $=+2.5 \mathrm{~V}$, MUX OUT connected to SHA IN.
All specifications $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ unless otherwise noted.)

| Parameter | A Versions ${ }^{1}$ | B <br> Versions | S <br> Version | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DYNAMIC PERFORMANCE ${ }^{2}$ |  |  |  |  | Any Channel |
| Signal to (Noise+Distortion) Ratio ${ }^{3}$ |  |  |  |  |  |
| @ $25^{\circ} \mathrm{C}$ | 70 | 72 | 70 | dB min | $\mathrm{f}_{\text {SAMPLE }}=500 \mathrm{kHz}^{4}$ |
| $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\mathrm{MAX}}$ | 70 | 70 | 70 | dB min |  |
| Total Harmonic Distortion ${ }^{3}$ | -78 | -78 | -78 | dB max | $\mathrm{f}_{\text {SAMPLE }}=500 \mathrm{kHz}^{4}$ |
| Peak Harmonic or Spurious Noise ${ }^{3}$ | -79 | -79 | -79 | dB max | $\mathrm{f}_{\text {SAMPLE }}=500 \mathrm{kHz}{ }^{4}$ |
| Intermodulation Distortion ${ }^{3}$ |  |  |  |  | $\mathrm{fa}=9 \mathrm{kHz}, \mathrm{fb}=9.5 \mathrm{kHz}, \mathrm{f}_{\text {SAMPLE }}=500 \mathrm{kHz}^{4}$ |
| 2nd Order Terms | -80 | -80 | -80 | dB typ |  |
| 3rd Order Terms | -80 | -80 | -80 | dB typ |  |
| Channel-to-Channel Isolation ${ }^{3}$ | -80 | -80 | -80 | dB max | $\mathrm{f}_{\mathrm{IN}}=1 \mathrm{kHz}$ Sine Wave |
| DC ACCURACY |  |  |  |  | Any Channel |
| Resolution | 12 | 12 | 12 | Bits |  |
| Minimum Resolution for Which |  |  |  |  |  |
| No Missing Codes are Guaranteed | 12 | 12 | 12 | Bits |  |
| Relative Accuracy ${ }^{3}$ | $\pm 1$ | $\pm 1 / 2$ | $\pm 1$ | LSB max |  |
| Differential Nonlinearity ${ }^{3}$ | $\pm 1$ | $\pm 1$ | $\pm 1$ | LSB max |  |
| Positive Full-Scale Error ${ }^{3}$ | $\pm 1$ | $\pm 1$ | $\pm 1$ | LSB max |  |
| Full-Scale Error Match ${ }^{3}$ | 1 | 1 | 1 | LSB max |  |
| Unipolar Offset Error | $\pm 1$ | $\pm 1$ | $\pm 1$ | LSB max | Input Ranges of 0 V to $+2.5 \mathrm{~V}, 0 \mathrm{~V}$ to +5 V |
| Unipolar Offset Error Match | 1 | 1 | 1 | LSB max | Input Ranges of 0 V to $+2.5 \mathrm{~V}, 0 \mathrm{~V}$ to +5 V |
| Negative Full-Scale Error ${ }^{3}$ | $\pm 1$ | $\pm 1$ | $\pm 1$ | LSB max | Input Ranges of $\pm 2.5 \mathrm{~V}, \pm 5 \mathrm{~V}, \pm 10 \mathrm{~V}$ |
| Bipolar Zero Error | $\pm 1$ | $\pm 1$ | $\pm 1$ | LSB max | ( Input Ranges of $\pm 2.5 \mathrm{~V}, \pm 5 \mathrm{~V}, \pm 10 \mathrm{~V}$ |
| Bipolar Zero Error Match | 1 | 1 | 1 | LSB max | Input Ranges of $\pm 2.5 \mathrm{~V}, \pm 5 \mathrm{~V}, \pm 10 \mathrm{~V}$ |
| ANALOG INPUTS |  |  | 4 ${ }^{4}$ | + ${ }^{\text {W }}$ |  |
| AD7891-1 Input Voltage Range |  |  | $\pm 5$. | Volts |  |
|  | $\pm 10$ | $\pm 10$ | $\pm 10$ | Volts | Input Applied to $\mathrm{V}_{\text {INXA }}, \mathrm{V}_{\text {INXB }}=A G N D$ |
| AD7891-1 $\mathrm{V}_{\text {INXA }}$ Input Resistance | 10 | 10 , 6 校 | 10 * | $\mathrm{k} \mathrm{R}_{\text {min }}$ | Input Range of $\pm 5 \mathrm{~V}$ |
| AD7891-1 $\mathrm{V}_{\text {INXA }}$ Input Resistance | 20 | 20 | 20 - | $k \Omega$ min | Input Range of $\pm 10 \mathrm{~V}$ |
| AD7891-2 Input Voltage Ra | $\begin{aligned} & 0 \text { to }+2.5 \\ & 0 \text { to }+5 \\ & \pm 2.5 \end{aligned}$ | $\begin{aligned} & 0 \text { to }+2.5 \\ & 0 \text { to }+5 \\ & \pm 2.5 \end{aligned}$ | $\begin{aligned} & 0 \text { to }+2.5 \\ & 0 \text { to }+5 \\ & \pm 2.5 \end{aligned}$ | Volts <br> Volts <br> Volts | Input Applied to Both $\mathrm{V}_{\text {INXA }}$ and $\mathrm{V}_{\text {INXB }}$ <br> Input Applied to $\mathrm{V}_{\text {INXA }}, \mathrm{V}_{\text {INXB }}=\mathrm{AGND}$ <br> Input Applied to $\mathrm{V}_{\text {INXA }}, \mathrm{V}_{\text {INXB }}=$ REF $\mathrm{IN}^{6}$ |
| AD7891-2 $\mathrm{V}_{\text {INXA }}$ Input Resistance AD7891-2 V | $\begin{aligned} & 1 \\ & \pm 50 \end{aligned}$ | $\begin{aligned} & 1 \\ & +50 \end{aligned}$ | $\begin{aligned} & 1 \\ & +50 \end{aligned}$ | $\mathrm{k} \Omega$ min $n A$ max | Input Ranges of $\pm 2.5 \mathrm{~V}$ and 0 V to +5 V Input Range of 0 V to +2.5 V |
| AD7891-2 $\mathrm{V}_{\text {INXA }}$ Input Current |  | $\pm 50$ | $\pm 50$ | nA max | Input Range of 0 V to +2.5 V |
| MUX OUT OUTPUT |  |  |  |  |  |
| Output Voltage Range | 0 to +2.5 | 0 to +2.5 | 0 to +2.5 | Volts |  |
| Output Resistance |  |  |  |  |  |
| AD7891-1 | 3/7 | 3/7 | 3/7 | $\mathrm{k} \Omega \min / \mathrm{k} \Omega$ max |  |
| AD7891-2 | 0.5/2.5 | 0.5/2.5 | 0.5/2.5 | $\mathrm{k} \Omega \min / \mathrm{k} \Omega$ max |  |
| SHA IN INPUT |  |  |  |  |  |
| Input Voltage Range | 0 to +2.5 | 0 to +2.5 | 0 to +2.5 | Volts |  |
| Input Current | $\pm 50$ | $\pm 50$ | $\pm 50$ | nA max |  |
| REFERENCE INPUT/OUTPUT |  |  |  |  |  |
| REF IN Input Voltage Range | 2.375/2.625 | 2.375/2.625 | 2.375/2.625 | V min/V max | $2.5 \mathrm{~V} \pm 5 \%$ |
| Input Impedance | 1.6 | 1.6 | 1.6 | $\mathrm{k} \Omega$ min | Resistor Connected to Internal Reference Node |
| Input Capacitance ${ }^{5}$ | 10 | 10 | 10 | pF max |  |
| REF OUT Output Voltage | 2.5 | 2.5 | 2.5 | $V$ nom |  |
| REF OUT Error @ + $25^{\circ} \mathrm{C}$ | $\pm 10$ | $\pm 10$ | $\pm 10$ | mV max |  |
| $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ | $\pm 20$ | $\pm 20$ | $\pm 25$ | mV max |  |
| REF OUT Temperature Coefficient | 25 | 25 | 25 | ppm $/{ }^{\circ} \mathrm{C}$ typ |  |
| REF OUT Output Impedance | 2 | 2 | 2 | $\mathrm{k} \Omega$ nom | See REF IN Input Impedance |
| LOGIC INPUTS |  |  |  |  |  |
| Input High Voltage, $\mathrm{V}_{\text {INH }}$ | 2.0 | 2.0 | 2.0 | $V$ min | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \%$ |
| Input Low Voltage, $\mathrm{V}_{\text {INL }}$ | 0.8 | 0.8 | 0.8 | $V$ max | $V_{D D}=5 \mathrm{~V} \pm 5 \%$ |
| Input Current, $\mathrm{I}_{\mathrm{IN}}$ | $\pm 10$ | $\pm 10$ | $\pm 10$ | $\mu \mathrm{A}$ max | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}$ |
| Input Capacitance, $\mathrm{C}_{\mathrm{IN}}{ }^{4}$ | 10 | 10 | 10 | pF max |  |

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## AD7891-SPECIFICATIONS

| Parameter | A <br> Versions ${ }^{1}$ | $\begin{aligned} & \hline B \\ & \text { Versions } \end{aligned}$ | $\mathbf{S}$ <br> Version | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| LOGIC OUTPUTS <br> Output High Voltage, $\mathrm{V}_{\mathrm{OH}}$ Output Low Voltage, $\mathrm{V}_{\mathrm{OL}}$ DB11-DB0 <br> Floating-State Leakage Current Floating-State Capacitance ${ }^{5}$ Output Coding | $\begin{aligned} & 4.0 \\ & 0.4 \\ & \pm 10 \\ & 15 \end{aligned}$ <br> Strai | $\begin{aligned} & 4.0 \\ & 0.4 \\ & \\ & \pm 10 \\ & 15 \\ & \\ & \text { (Natural) B } \\ & \text { mplement } \\ & \hline \end{aligned}$ | $\begin{aligned} & 4.0 \\ & 0.4 \\ & \pm 10 \\ & 15 \\ & \text { ary } \end{aligned}$ | V min <br> V max <br> $\mu \mathrm{A}$ max <br> pF max | $\begin{aligned} & \mathrm{I}_{\text {SOURCE }}=200 \mu \mathrm{~A} \\ & \mathrm{I}_{\text {SINK }}=1.6 \mathrm{~mA} \end{aligned}$ <br> Data Format Bit of Control Register $=0$ <br> Data Format Bit of Control Register $=1$ |
| CONVERSION RATE <br> Conversion Time Track/Hold Acquisition Time | $\begin{aligned} & 1.6 \\ & 0.4 \end{aligned}$ | $\begin{aligned} & 1.6 \\ & 0.4 \\ & \hline \end{aligned}$ | $\begin{aligned} & 1.6 \\ & 0.4 \\ & \hline \end{aligned}$ | $\mu \mathrm{s}$ max $\mu_{\mathrm{s}} \max$ | MUX OUT Connected to SHA IN |
| POWER REQUIREMENTS <br> $V_{D D}$ <br> $\mathrm{I}_{\mathrm{DD}}$ (Normal Mode) <br> $\mathrm{I}_{\mathrm{DD}}$ (Standby Mode) <br> Power Dissipation (Normal Mode) <br> Power Dissipation (Standby Mode) | $\begin{aligned} & +5 \\ & 15 \\ & 25 \\ & 75 \\ & 125 \\ & \hline \end{aligned}$ | $\begin{aligned} & +5 \\ & 15 \\ & 25 \\ & 75 \\ & 125 \\ & \hline \end{aligned}$ | $\begin{aligned} & +5 \\ & 15 \\ & 25 \\ & 75 \\ & 725 \\ & \hline \end{aligned}$ | V nom $m A$ max $\mu \mathrm{A}$ max mW max $\mu \mathrm{W}$ max | $\pm 5 \%$ for Specified Performance <br> Logic Inputs $=0 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{DD}}$ <br> Typically 60 mW <br> Typically $75 \mu \mathrm{~W}$ |

NOTES
${ }^{1}$ Temperature ranges are as follows: A, B Versions: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; $S$ Version: $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
${ }^{2}$ AD7891-1's dynamic performance is measured with an input frequency of 10 kHz while the AD7891-2's dynamic petformance is measured with an input frequency of 100 kHz .
${ }^{3}$ See Terminology.
${ }^{4}$ This sample rate can only be achieved when the part is operated in the parallel interface mode. Maximum achievable throughput rate in the serial interface mode is 385 kHz .
${ }^{5}$ Sample tested @ $+25^{\circ} \mathrm{C}$ to ensure compliance.
${ }^{6}$ REF IN must be buffered before being applied to $\mathrm{V}_{\text {INXB }}$.
Specifications subject to change without notice.
ABSOLUTE MAXIMUM RATINGS*
( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)
$V_{D D}$ to AGND ..... 0.3 V to +7 V
$V_{D D}$ to DGND ..... -0.3 V to +7 V
Analog Input Voltage to AGND
AD7891-1 ..... $\pm 17 \mathrm{~V}$
AD7891-2 ..... $\pm 5 \mathrm{~V}$
Reference Input Voltage to AGND ..... -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Digital Input Voltage to DGND ..... -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Digital Output Voltage to DGND

$\qquad$

$$
-0.3 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}
$$

Operating Temperature RangeCommercial (A, B Versions) $\ldots . . . . . . . . . .-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Extended (S Version). ..... $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range ..... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Junction Temperature ..... $+150^{\circ} \mathrm{C}$
PQFP Package, Power Dissipation ................ 450 mW
$\theta_{\mathrm{JA}}$ Thermal Impedance ..... $95^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature, Soldering
Vapor Phase ( 60 sec ) ..... $+215^{\circ} \mathrm{C}$
Infared ( 15 sec ) ..... 500 mW
$\theta_{\mathrm{JA}}$ Thermal Impedance ..... $55^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature, Soldering
Infared ( 15 sec ) ..... $+215^{\circ} \mathrm{C}$
$+220^{\circ} \mathrm{C}$
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD7891 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


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TIMING CHARACTERISTICS ${ }^{1,2}\left(v_{D D}=+5 \mathrm{v}\right.$, AGND $=\operatorname{DGND}=0 \mathrm{v}$, REF $\operatorname{IN}=+2.5 \mathrm{v}$, MUX OUT connected to SHA iN)


## NOTES

${ }^{1}$ Sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance. All input signals are measured with $\mathrm{tr}=\mathrm{tf}=1 \mathrm{~ns}(10 \%$ to $90 \%$ of $+5 \mathrm{~V})$ and timed from a voltage level of +1.6 V .
${ }^{2}$ See Figures 2 and 3.
${ }^{3}$ Specified using $10 \%$ and $90 \%$ points on the waveform of interest.
${ }^{4}$ Measured with the load circuit of Figure 1 and defined as the time required for an output to cross 0.8 V or 2.0 V .
${ }^{5}$ These times are derived from the measured time taken by the data outputs to change 0.5 V when loaded with the circuit of Figure 1 . The measured number is then extrapolated back to remove the effects of charging or discharging the 50 pF capacitor. This means that the times quoted in the timing characteristics are the true bus relinquish times of the part and as such are independent of external bus loading capacitances.
Specifications subject to change without notice.


Figure 1. Load Circuit for Access Time and Bus Relinquish Time

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| Mnemonic | Description |
| :---: | :---: |
| $\mathrm{V}_{\text {INXA }}, \mathrm{V}_{\text {INXB }}$ | Analog Input Channels. The AD7891 contains eight pairs of analog input channels. Each channel contains two input pins to allow a number of different input ranges to be used with the AD7891. There are two possible input voltage ranges on the AD7891-1. The $\pm 5 \mathrm{~V}$ input range is selected by connecting the input voltage to both $\mathrm{V}_{\text {INXA }}$ and $\mathrm{V}_{\text {INXB }}$, while the $\pm 10 \mathrm{~V}$ input range is selected by applying the input voltage to $\mathrm{V}_{\text {INXA }}$ and connecting $\mathrm{V}_{\text {INXB }}$ to AGND. The AD7891-2 has three possible input ranges. The 0 V to +2.5 V input range is selected by connecting the analog input voltage to both $\mathrm{V}_{\text {INXA }}$ and $\mathrm{V}_{\text {INXB }}$; the 0 V to +5 V input range is selected by applying the input voltage to $\mathrm{V}_{\text {INXA }}$ and connecting $\mathrm{V}_{\text {INXB }}$ to AGND; while the $\pm 2.5 \mathrm{~V}$ input range is selected by connecting the analog input voltage to $\mathrm{V}_{\text {INXA }}$ and connecting $\mathrm{V}_{\text {INXB }}$ to REF IN (provided this REF IN voltage comes from a low impedance source). <br> The channel to be converted is selected by the A2, A1 and A0 bits of the Control Register. In the parallel interface mode, these bits are available as three data input lines (DB3 to DB5) in a parallel write operation, while in the serial interface mode, these three bits are accessed via the DATA IN line in a serial write operation. The multiplexer has guaranteed break-before-make operation. |
| $\mathrm{V}_{\mathrm{DD}}$ | Positive supply voltage, $+5 \mathrm{~V} \pm 5 \%$. |
| AGND | Analog Ground. Ground reference for track/hold, comparator and |
| DGND | Digital Ground. Ground reference for digital circuitry. |
| $\overline{\text { STANDBY }}$ | Standby Mode Input. TTL-compatible input which is used to put the device into the power save or standby mode. The STANDBY input is high for normal operation and low for standby operation. |
| MUX OUT | Multiplexer Output. The output of the multiplexer appears at this pin. The output voltage range from this output is 0 V to +2.5 V for the nominal analog input range to the selected channel. The output impedance of this output is nominally $7.5 \mathrm{k} \Omega$ for the $A D 78914$ and $1 \mathrm{k} \Omega$ for the AD7891-2. If no external antialiasing filter or signal conditioning is required, MUX OUT should be connected to SHA IN. |
| SHA IN | Track/Hold Input. The input to the on-chip track/hold is applied to this pin. It is a high impedance input and the input voltage range is 0 V to +2.5 V . |
| $\mathrm{C}_{\text {EXT }}$ | External capacitor. An external capacitor is connected to this pin to determine the length of the internal pulse (see $\mathrm{C}_{\text {EXT }}$ FUNCTIONING section). Larger capacitances on this pin extend the pulse to allow for settling-time delays through an external antialiasing filter. |
| REF OUT/REF IN | Voltage Reference Output/Input. The part can either be used with its own internal reference or with an external reference source. The on-chip +2.5 V reference voltage is provided at this pin. When using this internal reference as the reference source for the part, REF OUT should be decoupled to AGND with a $0.1 \mu \mathrm{~F}$ disc ceramic capacitor. The output impedance of the reference source is typically $2 \mathrm{k} \Omega$. When using an external reference source as the reference voltage for the part, the reference source should be connected to this pin. This overdrives the internal reference and provides the reference source for the part. The reference pin is buffered on-chip but must be able to sink or source current through this $2 \mathrm{k} \Omega$ resistor to the output of the on-chip reference. The nominal reference voltage for correct operation of the AD7891 is +2.5 V . |
| CONVST | Convert Start. Edge-triggered logic input. A low to high transition on this input puts the track/hold into hold and initiates conversion. This CONVST signal is not gated with the internal pulse (see $\mathrm{C}_{\text {EXT }}$ FUNCTIONING section) and so the conversion is initiated from the rising edge of CONVST regardless of whether the internal pulse has timed out or not. |
| $\overline{\mathrm{EOC}}$ | End-of-Conversion. Active low logic output indicating converter status. The end of conversion is signified by a low going pulse on this line. The duration of this $\overline{\mathrm{EOC}}$ pulse is nominally 120 ns . |
| MODE | Interface Mode. Control input which determines the interface mode for the part. With this pin at a logic low, the AD7891 is in its serial interface mode; with this pin at a logic high, the device is in its parallel interface mode. |

[^79]| Mnemonic | Description |
| :---: | :---: |
| $\overline{\mathrm{CS}}$ | Chip Select. Active low logic input which is used in conjunction with $\overline{\mathrm{RD}}$ to enable the data outputs and with $\overline{\mathrm{WR}}$ to allow input data to be written to the part. |
| $\overline{\mathrm{RD}}$ | Read. Active low logic input which is used in conjunction with $\overline{\mathrm{CS}}$ low to enable the data outputs. |
| $\overline{\mathrm{WR}}$ | Write Input. Active low, logic input used in conjunction with $\overline{\mathrm{CS}}$ to latch the multiplexer address. The rising edge of this input also initiates an internal pulse, the width of which is determined by the value of capacitance on the $\mathrm{C}_{\text {EXt }}$ pin. When this pulse is active, it gates off the software conversion start until the pulse has timed out. This allows an external antialiasing filter (the output of which is applied to SHA IN) to settle when a channel address is changed before the track/hold goes into hold and conversion is initiated. If the SWCON bit of the Control Register is set to 1 , when this pulse times out, the track/hold then goes into hold and conversion is initiated. If the SWCON bit of the Control Register is set to 0 , the track/hold and conversion sequence are unaffected by the $\overline{\mathrm{WR}}$ operation. |

## Data I/O Lines

There are twelve data input/output lines on the AD7891. When the part is configured for parallel mode (MODE $=1$ ), the output data from the part is provided at these 12 pins during a read operation. For a write operation in parallel mode, these lines provide access to the part's Control Register.

## Parallel Read Operation

During a parallel read operation the 12 lines become the 12 data bit containing the conversion result from the AD7891. These data bits are labelled Data Bit 0 (LSB) to Data Bit 11 (MSB). They are three-state TTL-compatible outputs. Output data coding is 2 s complement when the DATA FORMAT Bit of the Control Register is 1 and straight binary when the DATA FORMAT Bit of the Control Register is 0 .

| Mnemonic | Description |
| :--- | :--- |
| $\mathrm{DB} 0-\mathrm{DB} 11$ | Data Bit $0(\mathrm{LSB})$ to Data Bit $11(\mathrm{MSB})$. Three state TT1-compatible outputs which are controlled by the $\overline{\mathrm{CS}}$ and |
|  | $\overline{\mathrm{RD}}$ inputs. |

## Parallel Write Operation

During a parallel write operation the following functions can be written to the Control Register via the 12 data input/output pins.

| Mnemonic | Description |
| :--- | :--- |
| A0 | Address Input. The status of this input during a parallel write operation is latched to the A0 bit of the Control <br> Register (see Control Register section). |
| A1Address Input. The status of this input during a parallel write operation is latched to the A1 bit of the Control <br> Register (see Control Register section). |  |
| A2Address Input. The status of this input during a parallel write operation is latched to the A2 bit of the Control <br> Register (see Control Register section). |  |
| SWCON | Software Conversion Start. The status of this input during a parallel write operation is latched to the SWCONV <br> bit of the Control Register (see Control Register section). <br> Software Standby Control. The status of this input during a parallel write operation is latched to the SWSTBY bit <br> of the Control Register (see Control Register section). <br> FORMAT Format Selection. The status of this input during a parallel write operation is latched to the FORMAT bit of <br> the Control Register (see Control Register section). |

## SERIAL INTERFACE MODE FUNCTIONS

When the part is configured for serial mode ( $\mathrm{MODE}=0$ ), five of the twelve data input/output lines provide serial interface functions. These functions are outlined below.

| Mnemonic | Description |
| :--- | :--- |
| SCLK | Serial Clock Input. This is an externally applied serial clock which is used to load serial data to the Control Regis- <br> ter and to access data from the output register. <br> TFS |
| Transmit Frame Synchronization Pulse. Active low logic input with serial data expected after the falling edge of <br> this signal. |  |

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$\overline{\overline{\mathrm{RFS}}} \quad$ Receive Frame Synchronization Pulse. This is an active low logic input with $\overline{\mathrm{RFS}}$ provided externally as a strobe or framing pulse to access serial data from the output register. For applications which require that data be transmitted and received at the same time, $\overline{\mathrm{RFS}}$ and $\overline{\mathrm{TFS}}$ should be connected together.
DATA OUT Serial Data Output. Sixteen bits of serial data are provided with the DATA FORMAT bit and the three address bits of the Control Register preceding the 12 bits of conversion data. Serial data is valid on the falling edge of SCLK for sixteen edges after $\overline{\mathrm{RFS}}$ goes low. Output conversion data coding is 2 s complement when the DATA FORMAT Bit of the Control Register is 1 and straight binary when the DATA FORMAT Bit of the Control Register is 0 .

## DATA IN

Serial Data Input. Serial data to be loaded to the Control Register is provided at this input. The first six bits of serial data are loaded to the Control Register on the first six falling edges of SCLK after TFS goes low. Serial data on subsequent SCLK edges is ignored while TFS remains low.

## PIN CONFIGURATIONS



ORDERING GUIDE

| Model | Input Ranges | Relative Accuracy | Temperature Range | Package Option^ |
| :--- | :--- | :--- | :--- | :--- |
| AD7891AS-1 | $\pm 5 \mathrm{~V}$ or $\pm 10 \mathrm{~V}$ | $\pm 1 \mathrm{LSB}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{S}-44$ |
| AD7891BS-1 | $\pm 5 \mathrm{~V}$ or $\pm 10 \mathrm{~V}$ | $\pm 1 / 2 \mathrm{LSB}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{S}-44$ |
| AD7891AP-1 | $\pm 5 \mathrm{~V}$ or $\pm 10 \mathrm{~V}$ | $\pm 1 \mathrm{LSB}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{P}-44 \mathrm{~A}$ |
| AD7891BP-1 | $\pm 5 \mathrm{~V}$ or $\pm 10 \mathrm{~V}$ | $\pm 1 / 2 \mathrm{LSB}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{P}-44 \mathrm{~A}$ |
| AD7891AS-2 | 0 V to $+2.5 \mathrm{~V}, 0 \mathrm{~V}$ to +5 V or $\pm 2.5 \mathrm{~V}$ | $\pm 1 \mathrm{LSB}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{S}-44$ |
| AD7891BS-2 | 0 V to $+2.5 \mathrm{~V}, 0 \mathrm{~V}$ to +5 V or $\pm 2.5 \mathrm{~V}$ | $\pm 1 / 2 \mathrm{LSB}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{S}-44$ |
| AD7891AP-2 | 0 V to $+2.5 \mathrm{~V}, 0 \mathrm{~V}$ to +5 V or $\pm 2.5 \mathrm{~V}$ | $\pm 1 \mathrm{LSB}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{P}-44 \mathrm{~A}$ |
| AD7891BP-2 | 0 V to $+2.5 \mathrm{~V}, 0 \mathrm{~V}$ to +5 V or $\pm 2.5 \mathrm{~V}$ | $\pm 1 / 2 \mathrm{LSB}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{P}-44 \mathrm{~A}$ |

*S = Plastic Quad Flatpack (PQFP); P = Plastic Leaded Chip Carrier (PLCC). For outline information see Package Information section.

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## CONTROL REGISTER

The Control Register for the AD7891 contains 6 bits of information as described below. These 6 bits can be written to the Control Register either in a parallel mode write operation or via a serial mode write operation. The default (power-on) condition of all bits in the Control Register is 0 .

MSB

| A2 | A1 | A0 | SWCONV | SWSTBY | FORMAT |
| :--- | :--- | :--- | :--- | :--- | :--- |

A2
A1
A0
the Input. Least significant address input for multiplexer channel selection. When the address is written to the control register, an internal pulse is initiated, the pulse width of which is determined by the value of capacitance on the $\mathrm{C}_{\text {EXT }}$ pin. SWCON will not sample the input signal or initiate a conversion until this pulse has timed out. This allows for the multiplexer settling time and track/hold acquisition time before the track/hold goes into hold and conversion is initiated. In applications where there is an antialiasing filter between MUX OUT and SHA IN, the filter settling time can be taken into account before the input at SHA IN is sampled. When the internal pulse times out, the track/hold goes into hold and conversion is initiated.
Conversion Start. Writing a 1 to this bit initiates a conversion in a similar manner to the $\overline{\text { CONVST }}$ input. Continuous conversion starts do not take place when there is a 1 in this location. The internal pulse and the conversion process are initiated when a 1 is written to this bit. With a 1 in this bit, the hardware conversion start, i.e., the CONVST input, is disabled. Writing a 0 to this bit enables the hardware CONVST input.
SWSTBY Standby Mode Input. Writing a 1 to this bit places the device in its standby or power-down mode. Writing a 0 to this bit places the device in its normal operating mode.
FORMAT
Data Format. Writing a 0 to this bit determines that the conversion data output format is straight (natural) binary. This data format is generally be used for unipolar input ranges. Writing a 1 to this bit determines that the conversion data output format is $2 s$ complement. This output data format is generally used for bipolar input ranges.

## CIRCUIT DESCRIPTION

The AD7891 is an eight-channel, high speed, 12-bit data acquisition system. It provides the user with signal scaling, multiplexer, track/hold, reference, A/D converter and high speed parallel and serial interface logic functions on a single chip. The signal conditioning on the AD7891-1 allows the part to accept analog input ranges of $\pm 5 \mathrm{~V}$ or $\pm 10 \mathrm{~V}$ when operating from a single supply. The input circuitry on the AD7891-2 allows the part to handle input signal ranges of 0 V to $+2.5 \mathrm{~V}, 0 \mathrm{~V}$ to +5 V and $\pm 2.5 \mathrm{~V}$ again while operating from a single +5 V supply. The part requires a +2.5 V reference which can be provided from the part's own internal reference or from an external reference source.
Unlike other single chip solutions, the AD7891 provides the user with separate access to the multiplexer and the $A / D$ converter. This means that the flexibility of separate multiplexer and ADC solutions is not sacrificed with the one-chip solution. With access to the multiplexer output, the user can implement external signal conditioning between the multiplexer and the track/hold. It means that one antialiasing filter can be used on the output of the multiplexer to provide the antialiasing function for all eight channels. The extra settling time introduced into the circuit by the external circuitry can be allowed for by the AD7891 by connecting a single capacitor to the $\mathrm{C}_{\text {EXT }}$ pin. If no external signal conditioning is required, the multiplexer output (MUX OUT) can simply be connected directly to the track/hold input (SHA IN).

Conversion is initiated on the AD7891 either by pulsing the CONVST input or by writing a logic 1 to the SWCONV bit of the Control Register. When using the hardware CONVST input, the on-chip track/hold goes from track to hold mode and the conversion sequence is started on the rising edge of the CONVST signal. When a software conversion start is initiated, an internal pulse is generated which delays the track/hold acquisition point and the conversion start sequence until the pulse is timed out. This internal pulse is initiated (goes from low to high) whenever a write to the AD7891 Control Register takes place with a 1 in the SWCONV bit. It then starts to discharge and the track/hold cannot go into hold and conversion cannot be initiated until the $\mathrm{C}_{\text {EXT }}$ pin has crossed its trigger point of 2.5 V . The discharge time of the voltage on $\mathrm{C}_{\mathrm{EXT}}$ depends upon the value of capacitor connected to the $\mathrm{C}_{\text {Ext }}$ pin.
The conversion clock for the part is internally generated and conversion time for the AD7891 is $1.6 \mu \mathrm{~s}$ from the rising edge of the hardware $\overline{\text { CONVST }}$ signal, and the track/hold acquisition time for the part is 400 ns . To obtain optimum performance from the part, the data read operation should not occur during the conversion or during 200 ns prior to the next conversion. This allows the part to operate at throughput rates up to 500 ksps in the parallel mode and achieve data sheet specifications. In the serial mode, the maximum achievable throughput rate for the part is 385 ksps (assuming a 20 MHz serial clock).

[^80] Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

## AD7891

## INTERFACE INFORMATION

The AD7891 provides two interface options, a 12-bit parallel interface and a high speed serial interface. The required interface mode is selected via the MODE pin. The two interface modes are discussed in the following sections.

## Parallel Interface Mode

The parallel interface mode is selected by tying the MODE input to a logic high. Figure 2 shows a timing diagram illustrating the operational sequence of the AD7891 in parallel mode for a hardware conversion start. The multiplexer address is written to the AD7891 on the rising edge of the $\overline{\mathrm{WR}}$ input. The on-chip track/hold goes into hold mode on the rising edge of CONVST, and conversion is also initiated at this point. When conversion is complete, the end of conversion line ( $\overline{\mathrm{EOC}}$ ) pulses low to indicate that new data is available in the AD7891's output register. This $\overline{\mathrm{EOC}}$ line can be used to drive an edge-triggered interrupt of a microprocessor. $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ going low accesses the 12 -bit conversion result. In systems where the part is interfaced to a gate array or ASIC, this EOC pulse can be applied to the $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ inputs to latch data out of the AD7891 and into the gate array or ASIC. This means that the gate array or ASIC does not need any conversion status recognition logic, and it also eliminates the logic required in the gate array or ASIC to generate the read signal for the AD7891.


Figure 2. Parallel Mode Timing Diagram

## Serial Interface Mode

The serial interface mode is selected by tying the MODE input to a logic low. In this case, five of the data/control inputs of the parallel mode assume serial interface functions. The serial interface on the AD7891 is a five-wire interface with read and write capabilities, with data being read from the output register via the DATA OUT line and data being written to the Control Register via the DATA IN line. The part operates in a slave or external clocking mode and requires an externally applied serial clock to the SCLK input to access data from the data register or write data to the control register. There are separate framing signals for the read ( $\overline{\mathrm{RFS}}$ ) and write ( $\overline{\mathrm{TFS}}$ ) operations.

## Read Operation

Figure 3 shows the timing diagram for reading from the AD7891 in serial mode. $\overline{\mathrm{RFS}}$ goes low to access data from the AD 7891. The serial clock input does not have to be continuous. The serial data can be accessed in a number of bytes. However, $\overline{\text { RFS }}$ must remain low for the duration of the data transfer operation. Sixteen bits of data are transmitted in serial mode with the data FORMAT bit, followed by the three address bits in the Control Register, followed by the 12-bit conversion result starting with the MSB. Serial data is clocked out of the device on the rising edge of SCLK and is valid on the falling edge of SCLK. At the end of the read operation, the DATA OUT line is three-stated by a rising edge on either the SCLK or $\overline{\mathrm{RFS}}$ inputs, whichever occurs first.


Figure 3. Serial Mode Read Operation

## Write Operation

Figure 4 shows a write operation to the Control Register of the AD7891. The TFS input goes low to indicate to the part that a serial write is about to occur. The AD7891 Control Register requires only six bits of data. These are loaded on the first six clock cyeles of the serial clock with data on all subsequent clock cycles being ignored. Serial data to be written to the AD7891 must be valid on the falling edge of SCLK.


Figure 4. Serial Mode Write Operation

## Simplifying the Serial Interface

To minimize the number of interconnect lines to the AD7891 in serial mode, the user can connect the $\overline{\mathrm{RFS}}$ and $\overline{\mathrm{TFS}}$ lines of the AD7891 together and read and write from the part simultaneously. In this case, new Control Register data line selecting the input channel and providing a conversion start command should be provided on the DATA IN while the part provides the result from the conversion just completed on the DATA OUT line.

[^81]
## C $_{\text {Ext }}$ FUNCTIONING

The $\mathrm{C}_{\text {EXT }}$ input on the AD7891 provides a means of determining how long after a new channel address is written to the part that a conversion can take place. The reason behind this is twofold. First, when the input channel to the AD7891 is changed, the input voltage on this new channel is likely to be very different from the previous channel voltage. Therefore, the part's track/hold has to acquire the new voltage before an accurate conversion can take place. An internal pulse delays any software conversion start command (as well as the signal to send the track/hold into hold) until after this pulse has timed out.
The second reason is to allow the user to connect external antialiasing or signal conditioning circuitry between MUX OUT and SHA IN. This external circuitry will introduce extra settling time into the system. The $\mathrm{C}_{\mathrm{EXT}}$ pin provides a means for the user to extend the internal pulse to take this extra settling time into account. Basically, varying the value of the capacitor on the $\mathrm{C}_{\text {EXT }}$ pin varies the duration of the internal pulse.

The duration of the internal pulse can be seen on the $\mathrm{C}_{\text {EXT }}$ pin. The $\mathrm{C}_{\text {EXT }}$ pin goes from a low to a high when a software conversion start is written to the part. Once the $\mathrm{C}_{\mathrm{EXt}}$ pin has discharged to crossing its nominal trigger point of 2.5 V , the internal pulse is timed out. With no capacitor on the $\mathrm{C}_{\text {EXT }}$ pin, the internal pulse duration is 600 ns .
If the multiplexer output (MUX OUT) is connected directly to the track/hold input (SHA IN), then external settling need not be taken into account by the internal pulse width. In this case, the 600 ns internal pulse duration with no $\mathrm{C}_{\text {EXT }}$ is sufficient to cater for the 400 ns acquisition time. If external circuitry is connected between MUX OUT and SHA IN, then the extra settling time introduced by this circuitry will have to be taken into account by placing a larger value of capacitance on the $\mathrm{C}_{\mathrm{EXT}}$ pin.

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

FEATURES
$2 \mu s$ ADC with T/H
4-Channel MUX
AD899 Compatible
+5 Volt Operation
On-Chip Reference
$4 \mu \mathrm{~s}$ Voltage Output DAC
Fast Bus Access Time-75 ns

## APPLICATIONS

Servo Controls
Digitally Controlled Calibration
Process Control Equipment

## GENERAL DESCRIPTION

The AD8401 is a complete data acquisition and control system containing ADC, DAC, 4-channel MUX, and internal voltage reference. Built using CBCMOS, this monolithic circuit offers the user a complete system with very high package density and reliability.
The converter is a successive approximation ADC with $\mathrm{T} / \mathrm{H}$, and is capable of operating with conversion times as short as $2 \mu \mathrm{~s}$. Analog input bandwidth is 200 kHz , and DAC output voltage settling time is less than $4 \mu \mathrm{~s}$, making the AD8401 capable of controlling servo loops with speed and precision.

The 8-bit data interface provides both read and write operation for parallel bus interfaces to microcontrollers and DSP processors. An external 5 MHz clock sets the $2 \mu \mathrm{~s}$ conversion rate. Slower clocks reduce the conversion time and the internal power dissipation. The standard control lines: Reset, Busy, Interrupt, Read and Write complete the handshaking signals for microprocessor communication. A start trigger $\overline{\text { ST }}$ input allows precise sampling intervals in synchronous sampling applications.

FUNCTIONAL BLOCK DIAGRAM


The input multiplexer addressing is designed for direct interface to the AD899 hard-disk drive, read-channel device with no extra hardware or special software. Analog input range levels are likewise compatible with the AD899.
The AD8401 is designed to operate from a single +5 volt supply, which will give an ADC input range of 0 V to 3.0 V , and DAC output range of 0 V to 2.5 V .
The AD8401 is offered in the SOIC-28 surface mount package, and is guaranteed to operate over the extended industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.

ALELEAR

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| STATIC PERFORMANCE <br> Resolution <br> Total Unadjusted Error <br> Relative Accuracy <br> Differential Nonlinearity <br> Offset Error <br> Full-Scale Error <br> $\Delta$ Full-Scale/ $\Delta \mathrm{V}_{\mathrm{DD}}$ | N <br> TUE <br> INL <br> DNL <br> $\mathrm{V}_{\text {OSE }}$ $\mathrm{A}_{\mathrm{E}}$ | $\begin{aligned} & \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \mathrm{~T}_{\mathrm{A}}=\text { Full Temp Range } \\ & \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \mathrm{~T}_{\mathrm{A}}=\text { Full Temp Range } \\ & \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \end{aligned}$ | $\begin{aligned} & 8 \\ & -1 \\ & -1 \\ & -4 \\ & -6 \\ & -4 \\ & -6 \end{aligned}$ | $\pm 3$ | $\begin{aligned} & +1 \\ & +1 \\ & +4 \\ & +6 \\ & +4 \\ & +6 \\ & 1 \end{aligned}$ | Bits LSB LSB LSB LSB LSB LSB LSB LSB |
| DYNAMIC PERFORMANCE <br> Signal-to-Noise Ratio Total Harmonic Distortion Intermodulation Distortion Frequency Response Track/Hold Acquisition Time | $\begin{aligned} & \text { SNR } \\ & \text { THD } \\ & \mathrm{IMD} \\ & \mathrm{t}_{\mathrm{AQ}} \end{aligned}$ | 0 to 200 kHz |  | $\begin{aligned} & 44 \\ & 48 \\ & 60 \\ & 0.1 \\ & 200 \end{aligned}$ |  | dB <br> dB <br> dB <br> dB <br> ns |
| ANALOG INPUTS (Applies <br> Unipolar Input Range <br> Input Current <br> Input Capacitance | $\begin{aligned} & \text { outs } \mathrm{A}, \mathrm{~B} \text {, } \\ & \mathrm{V}_{\mathrm{IN}} \\ & \mathrm{I}_{\mathrm{IN}} \\ & \mathrm{C}_{\mathrm{IN}} \end{aligned}$ |  | $\begin{aligned} & 0 \\ & -500 \end{aligned}$ |  | $\begin{aligned} & 3 \\ & +500 \end{aligned}$ | V <br> $\mu \mathrm{A}$ <br> pF |
| LOGIC INPUTS <br> Clock Input Current Low Clock Input Current High Input Leakage Current | $\mathrm{I}_{\mathrm{CKL}}$ <br> $\mathrm{I}_{\mathrm{CKH}}$ <br> $\mathrm{I}_{\mathrm{L}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{DD}} \\ & \overline{\mathrm{CS}}, \overline{\mathrm{RD}}, \overline{\mathrm{RS}}, \overline{\mathrm{ST}} \end{aligned}$ | 1.6 |  | $\begin{aligned} & 40 \\ & 10 \end{aligned}$ | mA <br> $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ |
| LOGIC OUTPUTS (Applies to <br> Logic Output Low Voltage Logic Output High Voltage Output Leakage Current Output Capacitance | puts DB0 <br> $\mathrm{V}_{\mathrm{OL}}$ <br> $\mathrm{V}_{\mathrm{OH}}$ <br> $\mathrm{I}_{\mathrm{OZ}}$ <br> $\mathrm{C}_{\mathrm{OZ}}$ | $\begin{aligned} & 7, \overline{\overline{\text { INT}}, \overline{\mathrm{BUSY}})} \\ & \mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OH}}=200 \mu \mathrm{~A} \\ & \overline{\mathrm{CS}}=1 \text { (Except } \overline{\mathrm{INT}} \& \overline{\mathrm{BUSY}}) \\ & \overline{\mathrm{CS}}=1 \text { (Except } \overline{\mathrm{INT}} \& \overline{\mathrm{BUSY}}) \end{aligned}$ | 4.0 |  | $\begin{aligned} & 0.4 \\ & 10 \\ & 10 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mu \mathrm{~A} \\ & \mathrm{pF} \end{aligned}$ |
| CONVERSION TIME | ${ }^{\text {t }}$ | External Clock |  |  | 2 | $\mu \mathrm{s}$ |

Specifications subject to change without notice.
Table I. Multiplexer Address Input Decode

| A1 | A0 | Input Selected |
| :--- | :--- | :--- |
| 0 | 0 | $\mathrm{~V}_{\text {IN }} \mathrm{A}$ |
| 0 | 1 | $\mathrm{~V}_{\text {IN }} \mathrm{B}$ |
| 1 | 0 | $\mathrm{~V}_{\text {IN }} \mathrm{C}$ |
| 1 | 1 | $\mathrm{~V}_{\text {IN }} \mathrm{D}$ |



| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| STATIC PERFORMANCE <br> Resolution <br> Total Unadjusted Error <br> Relative Accuracy <br> Differential Nonlinearity <br> Offset Error <br> Full-Scale Error <br> $\Delta$ Full-Scale/ $\Delta \mathbf{V}_{\text {DD }}$ <br> Load Regulation at Full-Scale | N <br> TUE <br> INL <br> DNL <br> $\mathrm{V}_{\text {OSE }}$ <br> $\mathrm{A}_{\mathrm{E}}$ | $\begin{aligned} & \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \mathrm{~T}_{\mathrm{A}}=\text { Full Temp Range } \\ & \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \mathrm{~T}_{\mathrm{A}}=\text { Full Temp Range } \\ & \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \end{aligned}$ | $\begin{aligned} & 8 \\ & -1 \\ & -1 \\ & -2 \\ & -2.5 \\ & -3 \\ & -4 \\ & -0.5 \\ & -0.2 \end{aligned}$ | $\pm 2$ | $\begin{aligned} & +1 \\ & +1 \\ & +2 \\ & +2.5 \\ & +3 \\ & +4 \\ & +0.5 \\ & +0.2 \end{aligned}$ | Bits <br> LSB <br> LSB <br> LSB <br> LSB <br> LSB <br> LSB <br> LSB <br> LSB <br> LSB |
| DYNAMIC PERFORMANCE <br> Signal-to-Noise Ratio Total Harmonic Distortion | $\begin{aligned} & \text { SNR } \\ & \text { THD } \end{aligned}$ |  |  | $\begin{aligned} & 44 \\ & 48 \end{aligned}$ |  | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \end{aligned}$ |
| ANALOG OUTPUT Output Voltage Range | OVR |  | 0 |  | +2.5 | V |
| LOGIC INPUTS (Applies to D <br> Logic Input Low Voltage Logic Input High Voltage Input Leakage Current Input Capacitance | DB7, $\overline{\mathrm{CS}}$, <br> $V_{\text {IL }}$ <br> $\mathrm{V}_{\mathrm{IH}}$ <br> $\mathrm{I}_{\mathrm{L}}$ <br> $\mathrm{C}_{\mathrm{IL}}$ |  | $\begin{gathered} 2.4 \\ -10 \end{gathered}$ |  | $\begin{aligned} & 0.8 \\ & 10 \\ & 10 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mu \mathrm{~A} \\ & \mathrm{pF} \end{aligned}$ |
| AC CHARACTERISTICS <br> Voltage Output Settling Time Positive Full-Scale Change Negative Full-Scale Change DAC Glitch Impulse Digital Feedthrough $\mathrm{V}_{\text {IN }}$ to $\mathrm{V}_{\text {OUt }}$ Isolation | $\mathrm{t}_{\mathrm{s}}$ <br> $\mathrm{t}_{\mathrm{POS}}$ <br> $\mathrm{t}_{\text {NEG }}$ | $\begin{aligned} & \text { To } \pm 1 / 2 \text { LSB of Final Value } \\ & 10 \% \text { to } 90 \% \\ & 90 \% \text { to } 10 \% \\ & \mathrm{f}=50 \mathrm{kHz} \end{aligned}$ |  | $\begin{aligned} & 2 \\ & 1 \\ & 2 \\ & 15 \\ & 1 \\ & 60 \end{aligned}$ | $\begin{aligned} & 4 \\ & 2 \\ & 4 \end{aligned}$ | $\begin{aligned} & \mu \mathrm{s} \\ & \mu \mathrm{~s} \\ & \mu \mathrm{~s} \\ & \mathrm{nV} \mathrm{~s} \\ & \mathrm{nV} \mathrm{~s} \\ & \mathrm{~dB} \end{aligned}$ |
| POWER REQUIREMENTS <br> Positive Supply Current | $\mathrm{I}_{\mathrm{DD}}$ | No Load |  |  | 13 | mA |

[^82]
# TIMING ELECTRICAL SPECIFICATIONS <br> $\left(@ V_{D D}=+5.0 \mathrm{~V} \pm 5 \%, \mathrm{AG}_{\mathrm{DCC}}=\mathrm{AG}_{\mathrm{ADC}}=0.0 \mathrm{~V} ; \mathrm{f}_{\mathrm{CLK}}=5 \mathrm{MHz} ;\right.$ <br> $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$, unless otherwise noted) 

| Parameter ${ }^{\text {1, 2, }} 3$ | Symbol | Condition | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DAC TIMING (See Figure 8 Timing Diagram) $\overline{\mathrm{WR}}$ Pulse Width $\overline{\mathrm{CS}}$ to $\overline{\mathrm{WR}}$ Setup Time $\overline{\mathrm{CS}}$ to $\overline{\mathrm{WR}}$ Hold Time Data Setup Time Data Hold Time | $\begin{aligned} & \mathrm{t}_{1} \\ & \mathrm{t}_{2} \\ & \mathrm{t}_{3} \\ & \mathrm{t}_{4} \\ & \mathrm{t}_{5} \end{aligned}$ |  | $\begin{aligned} & 50 \\ & 0 \\ & 0 \\ & 60 \\ & 0 \end{aligned}$ |  |  | ns <br> ns <br> ns <br> ns <br> ns |
| ADC TIMING (See Figures 6 and 7 Timing Diagrams) <br> $\overline{S T}$ Pulse Width <br> $\overline{\text { ST }}$ to $\overline{\text { BUSY }}$ Delay <br> $\overline{\text { BUSY }}$ to $\overline{\text { INT }}$ Delay <br> $\overline{\text { BUSY }}$ to $\overline{\text { CS }}$ Delay <br> $\overline{\mathrm{CS}}$ to $\overline{\mathrm{RD}}$ Setup Time <br> $\overline{\mathrm{RD}}$ Pulse Width ${ }^{4}$ <br> $\overline{\mathrm{CS}}$ to $\overline{\mathrm{RD}}$ Hold Time <br> Data Access after $\overline{\mathrm{RD}}$ <br> Data Access after $\overline{\mathrm{RD}}$ <br> Bus Relinquish after $\overline{\mathrm{RD}}$ <br> $\overline{\mathrm{RD}}$ to $\overline{\mathrm{INT}}$ Delay <br> $\overline{\mathrm{RD}}$ to $\overline{\mathrm{BUSY}}$ Delay <br> Data Valid after $\overline{\text { BUSY }}$ <br> Data Valid after $\overline{B U S Y}$ | $t_{6}$ <br> $\mathrm{t}_{7}$ <br> $\mathrm{t}_{8}$ <br> $t_{9}$ <br> $t_{10}$ <br> $t_{11}$ <br> $t_{12}$ <br> $t_{13}$ <br> $t_{13}$ <br> $\mathrm{t}_{14}$ <br> $\mathrm{t}_{15}$ <br> $t_{16}$ <br> $t_{17}$ <br> $t_{17}$ | $\begin{aligned} & \mathrm{C}_{\mathrm{L}}=20 \mathrm{pF} \\ & \mathrm{C}_{\mathrm{L}}=100 \mathrm{pF} \end{aligned}$ $\begin{aligned} & C_{L}=20 \mathrm{pF} \\ & C_{L}=100 \mathrm{pF} \end{aligned}$ | $\begin{aligned} & 40 \\ & \\ & 0 \\ & 0 \\ & 75 \\ & 0 \\ & 10 \\ & 10 \\ & 10 \end{aligned}$ |  | $\begin{aligned} & 110 \\ & 30 \end{aligned}$ <br> 75 <br> 135 <br> 70 <br> 85 <br> 110 <br> 90 <br> 135 | ns <br> ns <br> ns <br> ns <br> ns <br> ns <br> ns <br> ns <br> ns <br> ns <br> ns <br> ns <br> ns <br> ns |

## NOTES

${ }^{1}$ All input control signals are specified with $t_{R}=t_{F}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of $+5 \mathrm{~V})$ and timed from a voltage level of 1.6 V .
${ }^{2} t_{13}$ and $t_{17}$ are measured with the load circuits of Figure 1 and defined as the time required for an output to cross either 0.8 V or 2.4 V .
${ }^{3} \mathrm{t}_{14}$ is defined as the time required for the data line to change 0.5 V when loaded with the circuit of Figure 2.
${ }^{4} t_{11}$ is determined by $t_{13}$.

a. High $Z$ to $V_{O H}$ b. High $Z$ to $V_{O L}$

Figure 1. Load Circuits for Data Access Time Test

## ABSOLUTE MAXIMUM RATINGS*

Supply Voltage ( $\mathrm{V}_{\mathrm{DD}}$ ) . . . . . . . . . . . . . . . . . . . . . . . +8 V Input Voltages . . . . . . . . . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ Output Short-Circuit Duration . . . . . . . . . . . . . . . Indefinite Package Power Dissipation . . . . . . . . . . . . $\left(\mathrm{T}_{\mathrm{J}} \max -\mathrm{T}_{\mathrm{A}}\right) / \theta_{\mathrm{JA}}$ Thermal Resistance $\theta_{\text {JA }}$

28-Lead SOIC (R) . . . . . . . . . . . . . . . . . . . . . . . 53 $\mathrm{C} / \mathrm{W}$
Storage Temperature Range . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Operating Temperature Range . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Junction Temperature Range ( $\mathrm{T}_{\mathrm{J}} \max$ ) . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature Range (Soldering, 60 sec ) . . . . . . $+300^{\circ} \mathrm{C}$
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. $V_{O H}$ to High $Z$
b. $V_{O L}$ to High $Z$

Figure 2. Load Circuits for Bus Relinquish Time Test

ORDERING GUIDE

| Model $^{\mathbf{1}}$ | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD8401AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 28-Lead SOIC <br>  <br> AD8401Chips | SOL-28 |

## NOTES

${ }^{1}$ The AD8401 contains 1257 transistors.
${ }^{2}$ For outline information see Package Information section.

PIN CONFIGURATION


DICE CHARACTERISTICS


## PIN DESCRIPTIONS

| Pin\# | Name | Description |
| :---: | :---: | :---: |
| 1 | $\mathrm{V}_{\mathrm{DD}}$ | Positive Supply. Nominal value +5 volts. This pad requires 2 bonds for die assembly. The substrate is common with $\mathrm{V}_{\mathrm{DD}}$. |
| 2 | $\mathrm{AG}_{\text {DAC }}$ | Analog Ground for the DAC. There is a separate analog ground for the ADC. |
| 3 | $\mathrm{V}_{\text {OUT }}$ | Voltage Output from the DAC. |
| 4 | NC | No Connect. |
| 5 | A1 | Address Input that controls multiplexer. See Table I for address decode. |
| 6 | RESET ( $\overline{\mathrm{RS}}$ ) | Active Low Digital Input that cleārs the DAC register to zero, setting the DAC to minimum scale. It also asynchronously clears the $\overline{\mathrm{INT}}$ line of the ADC. |
| $7-12,14,15$ | DB7 to DB0 | Digital I/O Lines. DB7 (7) is the Most Significant Bit (MSB), for both the ADC and the DAC, and DB0 (15) is the Least Significant Bit (LSB). |
| 13 | DGND | Digital Ground. |
| 16 | WR | Rising Edge Triggered Write Input. Used to load data into the DAC register. |
| 17 | $\overline{\mathrm{CS}}$ | Chip Select. Active Low Input |
| 18 | $\overline{\mathrm{RD}}$ | Active Low Read Input. When this input is active, ADC data can be read from the part. $\overline{\mathrm{RD}}$ going low starts the ADC conversion. |
| 19 | $\overline{\mathrm{ST}}$ | Falling Edge Triggered Start Input. Used for applications requiring precise sample timing. The falling edge of $\overline{\mathrm{ST}}$ starts the conversion and sets the $\overline{\mathrm{BUSY}}$ low. The $\overline{\mathrm{ST}}$ is not gated by $\overline{\mathrm{CS}}$. |
| 20 | $\overline{\text { BUSY }}$ | ADC Active Low, Status Output. When the ADC is performing a conversion, the $\overline{\mathrm{BUSY}}$ output is low. |
| 21 | $\overline{\mathrm{INT}}$ | Active Low Output. The Interrupt output notifies the system that the ADC has completed its conversion. $\overline{\mathrm{INT}}$ goes high on the rising edge of $\overline{\mathrm{CS}}$ or $\overline{\mathrm{RD}}$. It will also be forced high when RESET is asserted. |
| 22 | CLK | External Clock Input Pin. Accepts a TTL or 5 V CMOS input logic levels. |
| 23 | $\mathrm{AG}_{\text {ADC }}$ | Analog ADC Ground |
| 27-24 | $\mathrm{V}_{\mathrm{IN}} \mathrm{A}, \mathrm{B}, \mathrm{C}, \mathrm{D}$ | Four Analog Inputs |
| 28 | A0 | Address input that controls multiplexer. See Table I for address decode. |

## OPERATION

The AD8401 is a complete data acquisition and control system. It contains the DAC, a four channel input multiplexer, a track/ hold, an ADC, as well as an internal bandgap reference. It interfaces to the microcontroller via an 8 -bit digital I/O port.

## D/A CONVERTER SECTION

The DAC is an 8-bit voltage mode DAC with an output that swings from $\mathrm{AG}_{\text {Dac }}$ to the 1.25 volt bandgap voltage. It uses an R-2R ladder fed by PNP current sources which allow the output to swing to ground so that the DAC operates in a unipolar mode.

## AMPLIFIER SECTION

The DAC's output is buffered by an internal high speed op amp. The op amps output range is set at 0 V to 2.5 V . The op amp has a 500 ns typical settling time to $0.2 \%$ for positive slewing signals. There are differences in settling time for negative slewing signals. Signals going to zero volts will settle slightly slower to ground than is seen in the positive direction.


Figure 3. Equivalent Amplifier Output Stage
Current sinking capability is also limited near zero volts in single supply operation. Figure 3 provides an equivalent amplifier output stage schematic.

## INTERNAL REFERENCE

An on-chip bandgap is provided as a voltage reference to both the DAC and the ADC. This reference is internal to the AD8401 and is not accessible to the user. It is laser trimmed for both absolute accuracy and temperature coefficients. The reference is internally buffered by a separate control amplifier for both the DAC and ADC to improve isolation between the converters.

## DIGITAL I/O

The 8-bit parallel data I/O port on the AD8401 provides access to both the DAC and the ADC. This port is TTL/CMOS compatible with three-state outputs that are ESD protected.
The data format is binary. This data coding applies to both the DAC and the ADC. See the applications information section.

## ADC SECTION

A fast successive approximation ADC is used to attain a conversion time of 2 microseconds. Start of conversion is initiated by $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$. Following a Start command the $\overline{\text { BUSY }}$ signal will become active and another Start command should not be given until the conversion is complete.
The RESET ( $\overline{\operatorname{RS}}$ ) input does not affect A/D conversion, but the $\overline{\text { INT }}$ (Interrupt or conversion complete) which normally goes
active low at the end of a conversion will be forced high by RESET asynchronously.
Figure 4 shows the wave forms for a conversion cycle. The track and hold begins holding the input voltage $\mathrm{V}_{\text {IN }}$ approximately 50 ns after the falling edge of the Start command. The MSB decision is made approximately 50 ns after the second falling edge of the CLK. If $\mathrm{t}_{\mathrm{x}}$ is greater than 50 ns , then the falling edge of the CLK will be seen as the first falling clock edge. If $\mathrm{t}_{\mathrm{X}}$ is less than 50 ns , the first MSB conversion will not occur until one clock cycle later. The following bits will each be converted in a similar manner 50 ns after each CLK edge until all eight bits have been converted. After the end of conversion the contents of the ADC SAR register are transferred to the output data latch, the track and hold is returned to the track mode, $\overline{\text { INT }}$ goes low and the SAR is reset.


Figure 4. Operating Waveforms Using the External Clock

## ANALOG INPUT

The analog inputs of the AD8401 are fed into resistor voltagedivider networks with a typical value of $8.5 \mathrm{k} \Omega$. The amplifiers driving these inputs must have an output resistance low enough to drive these nodes without losing accuracy. Taps from the voltage dividers are connected to the track and hold amplifier by the multiplexer switches.


Figure 5. Equivalent Analog Input Circuit

## TRACK-AND-HOLD AMPLIFIER

Following the resistive divider at the input of the AD8401 is a track-and-hold amplifier that captures input signals accurately up to the 200 kHz Nyquist frequency of the ADC. To attain this performance the $\mathrm{T} / \mathrm{H}$ amplifier must have a much greater bandwidth than the signal of interest. Because of this the user must be careful to band limit the input signal to avoid aliasing high frequency components and noise into the passband.
The track-and-hold amplifier is internally controlled by the Start command and is not directly available to the user. After the Start command signal the track-and-hold is placed into the hold mode; it returns to the track mode after the conversion is complete.

## CLOCK

The AD8401 uses an external clock that is TTL or 5 V CMOS compatible. The external clock speed is 5 MHz and the duty cycle may vary from $30 \%$ to $70 \%$. The external clock can be continuously operated between conversions.

## DIGITAL INTERFACE: ADC TIMING AND CONTROL

Two basic ADC operating modes are available with the AD8401. The first mode uses the Start ( $\overline{\mathrm{ST}}$ ) pin to trigger a synchronized A/D conversion. As soon as the $\overline{S T}$ pin is asserted, the $\mathrm{T} / \mathrm{H}$ switches from tracking to the hold mode capturing the present analog input-voltage sample. With the T/H holding the analog sample the successive-approximation analog-to-digital conversion is completed on that sample value. At the end of conversion the T/H returns to the tracking mode. This mode of conversion is ideal for digital signal processing applications where precise interval sampling is necessary to minimize errors due to sampling uncertainty or jitter. A precise clock source can be used to drive the $\overline{\mathrm{ST}}$ input.
The second mode of conversion is started by the $\overline{\mathrm{RD}}$ and $\overline{\mathrm{CS}}$ inputs going low, after which the BUSY line puts the microprocessor into a WAIT state until end of conversion. Mode 2 is asserted by connecting the $\overline{\mathrm{ST}}$ pin to logic high. The major advantage of this interface is that a single Read Instruction will start and complete a new analog-to-digital conversion without the need for carefully tailored software delays that often are not portable when software routines are taken to a different processor running at a different clock speed.


Figure 6. Mode 1, ADC Interface Timing

## Mode 1 Interface

As shown in Figure 6, the falling edge of the $\overline{\text { ST }}$ pulse initiates a conversion and puts the T/H amplifier into the hold mode. The $\overline{\text { BUSY }}$ signal goes low during the whole $\mathrm{A} / \mathrm{D}$ conversion time and returns high signaling end of conversion. The INT line can be used to interrupt the microprocessor. When the microprocessor performs a READ to access the AD8401 data, the rising edges of $\overline{\mathrm{CS}}$ or $\overline{\mathrm{RD}}$ will reset the $\overline{\mathrm{INT}}$ output to high after the $\mathrm{t}_{15}$ timing specification. $\overline{\mathrm{INT}}$ can also be used to externally trigger a pulse that activates the $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ and places the new data into a buffer or First In First Out FIFO memory. The microprocessor can then load a series of readings from this buffer memory at a convenient time. Care must be taken not to have the $\overline{\mathrm{ST}}$ input high when $\overline{\mathrm{RD}}$ is brought low; otherwise, the AD8401 will not operate properly. Also triggering the $\overline{\text { ST }}$ line a second time before conversion is complete will cause erroneous readings.


Figure 7. Mode 2, ADC Interface Timing

## Mode 2 Interface

This interface mode can be used with microprocessors that can be put into a WAIT state for at least 2 microseconds. The ST pin must be tied to logic high for proper operation. The microprocessor begins a conversion by executing a READ instruction that asserts the $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ pins at the AD8401's decoded address. The AD8401 $\overline{\mathrm{BUSY}}$ output then goes low, forcing the microprocessor's READY (or WAIT) line into a WAIT state. The analog input signal is captured by the $\mathrm{T} / \mathrm{H}$ on the falling edge of $\overline{\mathrm{RD}}$. When the conversion is complete ( 8 clocks later), the BUSY line returns high, and then the $\mu \mathrm{P}$ completes its READ of the new data now on the digital output port of the AD8401. Note that while conversion is in progress the ADC places the results from the last conversion (Old Data) on the data bus. The Figure 7 timing diagram details the applicable timing specification requirements.

## DIGITAL INTERFACE: DAC TIMING AND CONTROL

Table II shows the truth table for DAC operation. The internal 8 -bit DAC register contents are loaded from the data bus when both $\overline{\mathrm{WR}}$ and $\overline{\mathrm{CS}}$ are asserted. The DAC register determines the $\mathrm{D} / \mathrm{A}$ converter analog-output voltage. The $\overline{\mathrm{WR}}$ input is a positive edge triggered input that loads the bus data into the DAC register subject to the data setup and data hold timing requirements. When $\overline{\mathrm{CS}}$ and $\overline{\mathrm{WR}}$ are low, the DAC register contents will not change with changing data bus values. Figure 8 provides the detail timing diagram for write cycle operation.

## Table II. DAC Register Logic

| $\overline{\mathbf{C S}}$ | $\overline{\mathbf{W R}}$ | $\overline{\mathbf{R S}}$ | DAC Function |
| :--- | :--- | :--- | :--- |
| H | H | H | No Effect |
| L | L | H | No Effect |
| L | $\wedge$ | H | DAC Register Updated |
| $\wedge$ | L | H | DAC Register Updated |
| $\mathbf{X}$ | X | L | DAC Register Loaded with all Zeros |



Figure 8. Write Cycle Timing

An active low pulse, at any time, on the RESET pin asynchronously forces all DAC register bits to zero. The DAC output voltage becomes zero volts and stays at that value until a new data word is loaded into the DAC register with a new $\overline{\mathrm{WR}}$ command. The equivalent input logic for the DAC register loading is shown in Figure 9.

## TYPICAL PERFORMANCE CHARACTERISTICS



Figure 10. ADC Linearity Error vs. Digital Code


Figure 11. DAC Linearity Error vs. Digital Code


Figure 9. Equivalent DAC Register Control Logic


Figure 12. ADC Full-Scale Error Histogram


Figure 13. ADC Full-Scale Error vs. Temperature


Figure 14. DAC Full-Scale Error Histogram


Figure 15. DAC Full-Scale Error vs. Temperature


Figure 16. DAC Full-Scale Out Change vs. Time Accelerated by Burn-In


Figure 17. DAC Output Swing vs. Load Resistance


Figure 18. DAC Output Slew Rate Positive Transition


Figure 19. DAC Output Slew Rate Negative Transition


Figure 20. DAC Output Swing with Capacitive Load


Figure 21. Supply Current vs. Temperature


Figure 22. Power Supply Rejection Ratio vs. Frequency

## APPLICATIONS INFORMATION

The software programming needs to format data as defined by the transfer equations and Code Tables that follow.

## DAC Transfer Equation

$V_{\text {OUT }}=2.500 \times \frac{D}{256}=2.500 \times \frac{255}{256}$ for a 2.50 V full scale where $D$ is the decimal value 0 through 255 of the 8 -bit data word.

Table III. DAC Unipolar Code

| DAC Register Contents |  | General Transfer Equation | Nominal Analog <br> Output $\mathrm{V}_{\text {out }}$ |
| :---: | :---: | :---: | :---: |
| Decimal | Binary |  |  |
| 255 | 11111111 | $2.500 \times \frac{255}{256}$ | 2.490 V |
| 129 | 10000001 | $2.500 \times \frac{129}{256}$ | 1.260 |
| 128 | 10000000 | $2.500 \times \frac{128}{256}$ | 1.250 |
| 127 | 01111111 | $2.500 \times \frac{127}{256}$ | 1.240 |
| 1 | 00000001 | $2.500 \times \frac{1}{256}$ | 0.010 |
| 0 | 00000000 | $2.500 \times \frac{0}{256}$ | 0.000 |

The nominal output voltages listed in the Code Table are subject to the static performance specifications. The INL, ZeroScale and Full-Scale errors describe the total specified variation that will be encountered from part to part. One LSB of error for the 2.5 V FS range is 9.766 millivolts ( $=2.50 / 256$ ).
Although separate AGNDs exist for both the DAC and ADC to minimize crosstalk, writing data to the DAC while the ADC is performing a conversion may result in an incorrect conversion from the ADC due to signal interaction between the DAC and ADC. Therefore, to ensure correct operation of the ADC, the DAC register should not be updated while the ADC is converting.
The AD8401 is configured for an input range of +3.0 volts Full Scale. The nominal transfer characteristic for this range is plotted in Figure 23. The output coding is natural binary with one LSB equal to 11.72 millivolts. Note that the first code transition between 0 and 1 LSB occurs at 5.8 mV , one half of the 11.72 mV LSB step size. The last code transition occurs at Full Scale minus 1.5 LSBs, which is a 2.982 V input.
The AD8401 is easily interfaced to most microprocessors by using either address bits or address decode to select the appropriate multiplexer channel. Figure 24 shows how easily the AD8401 interfaces to the AD899. No additional hardware is required.


Figure 23. $A D C O V$ to $+3 V$ Input Transfer Characteristic


Figure 24. AD8401 Interface to the AD899 Read-Channel Hard Disk Drive Circuit

## Sample/Track-Hold Amplifiers Contents

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## Selection Tree - Sample/Track-Hold Amplifiers



Selection Guide-Sample/Track-Hold Amplifiers

| Model | Specified <br> Accuracy <br> \% | Acquisition Time $\mu \mathrm{s}$ $\max ^{\boldsymbol{x}}$ | Aperture Time ns typ | Aperture Jitter <br> ns typ | Droop Rate $\mu \mathrm{V} / \mu \mathrm{s}$ max | Package Options ${ }^{1}$ | Temp Ranges ${ }^{2}$ | Comments | Page ${ }^{3}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| AD1154 | 0.00076 | 5.0 | 80 | 0.15 | 0.1 | D | C, I | Low Cost 16-Bit Accurate, High Speed Amplifier | CII 4-69 |
| AD9100 | 0.01 | 0.023 | 0.8 | $<0.001$ | 6000 | D, J | C, I, M | Ultrahigh Speed Monolithic T/H, Low Distortion | 6-22 |
| AD783 | 0.01 | 0.375 | 15 | 0.01 | 1 | Q, R | C, I, M/ | Complete 375 ns Sample-and-Hold Amplifier | 6-14 |
| AD781 | 0.01 | 0.7 | 25 | 0.05 | 1 | N, $\mathbf{Q}$ | C, I, M | Complete 700 ns Sample-and-Hold Amplifier | 6-11 |
| AD684 | 0.01 | 1.0 | 20 | 0.1 | 1 | Q | C, I, M/ | Quad, Monolithic $1 \mu \mathrm{~s}$ SHA | 6-8 |
| AD585 | 0.01 | 3.0 | 35 | 0.5 | 1 | $\mathbf{E}, \mathbf{P}, \mathbf{Q}$ | C, I, M/ ${ }_{\text {D }}$ | High Speed, Precision, On-Board Hold Cap | 6-5 |
| SMP10 | 0.01 | 3.5 | 50 | 1 | 0.02 | Q | C, M/D | Low Droop Rate, High Sample/Hold Current Ratio | CII 4-109 |
| SMP11 | 0.01 | 3.5 | 50 | 1 | 0.2 | N, Q | C, $\mathrm{I}, \mathrm{M} /{ }_{\text {DJ }}$ | Low Droop Rate, Fast Hold Mode Settling Time | CII 4-109 |
| SMP18 | 0.01 | 3.5 | - | - | 0.04 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I | Fast SMP08 | 6-34 |
| SMP04 | 0.01 | 7.0 | - | - | 0.025 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | CMOS, Quad Sample-and-Hold Amplifier, Low Cost | 6-28 |
| SMP81 | 0.045 | 3.5 | 50 | 1 | 2.0 | Q | I | High Accuracy, Fast Acquisition for PCM Encodes | D |
| AD582 | 0.1 | 6.0 | 200 | 15 |  | D, M | C, M/ | Low Cost, $15 \mu \mathrm{~s}$ | CII 4-29 |
| SMP08 | 0.1 | 7.0 | - | - | 0.02 | $\mathbf{M}, \mathbf{Q}, \mathbf{R}$ | I, M | Octal, Sample-and-Hold with Multiplexed Input | 6-31 |
| AD9101 | 0.1 | 0.007 | 0.5 | $<0.001$ | 9000 | E, R | C, I, M | 100 MSPS Track-and-Hold Samplifier ${ }^{\text {TM }}$ | 6-25 |

[^83]
## FEATURES

3.0ps Acquisition Time to $\pm \mathbf{0 . 0 1 \%}$ max

Low Droop Rate: $1.0 \mathrm{mV} / \mathrm{ms}$ max
Sample/Hold Offset Step: 3mV max
Aperture Jitter: 0.5ns
Extended Temperature Range: $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Internal Hold Capacitor
Internal Application Resistors
$\pm 12 \mathrm{~V}$ or $\pm 15 \mathrm{~V}$ Operation
Available in Surface Mount
APPLICATIONS
Data Acquisition Systems
Data Distribution Systems
Analog Delay \& Storage
Peak Amplitude Measurements
MIL-STD-883 Compliant Versions Available

## PRODUCT DESCRIPTION

The AD585 is a complete monolithic sample-and-hold circuit consisting of a high performance operational amplifier in series with an ultralow leakage analog switch and a FET input integrating amplifier. An internal holding capacitor and matched applications resistors have been provided for high precision and applications flexibility.

The performance of the AD585 makes it ideal for high speed 10 - and 12 -bit data acquisition systems, where fast acquisition time, low sample-to-hold offset, and low droop are critical. The AD585 can acquire a signal to $\pm 0.01 \%$ in $3 \mu \mathrm{~s}$ maximum, and then hold that signal with a maximum sample-to-hold offset of 3 mV and less than $1 \mathrm{mV} / \mathrm{ms}$ droop, using the on-chip hold capacitor. If lower droop is required, it is possible to add a larger external hold capacitor.

The high-speed analog switch used in the AD585 exhibits aperture jitter of 0.5 ns , enabling the device to sample full-scale ( 20 V peak-to-peak) signals at frequencies up to 78 kHz with 12 -bit precision.
The AD585 can be used with any user-defined feedback network to provide any desired gain in the sample mode. On-chip precision thin-film resistors can be used to provide gains of $+1,-1$, or +2 . Output impedance in the hold mode is sufficiently low to maintain an accurate output signal even when driving the dynamic load presented by a successive-approximation A/D converter. However, the output is protected against damage from accidental short circuits.
The control signal for the HOLD command can be either active high or active low. The differential HOLD signal is compatible with all logic families, if a suitable reference level is provided. An on-chip TTL reference level is provided for TTL compatibility.


LCC/PLCC PACKAGE


The AD585 is available in three performance grades. The JP grade is specified for the 0 to $+70^{\circ} \mathrm{C}$ commercial temperature range and packaged in a 20 -pin PLCC. The AQ grade is specified for the $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ industrial temperature range and is packaged in a 14 -pin cerdip. The SQ and SE grades are specified for the $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ military temperature range and are packaged in a 14 -pin cerdip and 20 -pin LCC.

## PRODUCT HIGHLIGHTS

1. The fast acquisition time ( $3 \mu \mathrm{~s}$ ) and low aperture jitter ( 0.5 ns ) make it the first choice for very high speed data acquisition systems.
2. The droop rate is only $1.0 \mathrm{mV} / \mathrm{ms}$ so that it may be used in slower high accuracy systems without the loss of accuracy.
3. The low charge transfer of the analog switch keeps sample-tohold offset below 3 mV with the on-chip 100 pF hold capacitor, eliminating the trade-off between acquisition time and $\mathrm{S} / \mathrm{H}$ offset required with other SHAs.
4. The AD585 has internal pretrimmed application resistors for applications versatility.
5. The AD585 is complete with an internal hold capacitor for ease of use. Capacitance can be added externally to reduce the droop rate when long hold times and high accuracy are required.
6. The AD585 is recommended for use with 10 - and 12 -bit successive-approximation A/D converters such as AD573, AD574A, AD674A, AD7572 and AD7672.
7. The AD585 is available in versions compliant with MIL-STD883. Refer to the Analog Devices Military Products Databook or current AD585/883B data sheet for detailed specifications.
(typical @ $+25^{\circ} \mathrm{C}$ and $\mathrm{V}_{\mathrm{S}}= \pm 12 \mathrm{~V}$ or $\pm 15 \mathrm{~V}$, and $\mathrm{C}_{\mathrm{H}}=$ Internal, $\mathrm{A}=+1$, HOLD active unless otherwise specified)


NOTES
${ }^{1}$ Maximum input signal is the minimum supply minus a headroom voltage
of 2.5 V .
${ }^{2}$ Not tested at $-55^{\circ} \mathrm{C}$.
${ }^{3} \mathrm{E}=$ Leadless Ceramic Chip Carrier; $\mathrm{P}=$ Plastic Leaded Chip Carrier; $\mathrm{Q}=$ Cerdip.
For outline information see Package Information section.
${ }^{4}$ For AD585/883B specifications, refer to Analog Devices Military Products Databook.
Specifications subject to change without notice.
Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All $\min$ and max specifications are guaranteed, although only those shown in boldface are tested on all production units.

## ABSOLUTE MAXIMUM RATINGS

Supplies (+ $V_{S},-V_{S}$ ) . . . . . . . . . . . . . . . . . . $\pm 18 \mathrm{~V}$
Logic Inputs . . . . . . . . . . . . . . . . . . . . . . . $\pm \mathrm{V}_{\mathrm{S}}$
Analog Inputs . . . . . . . . . . . . . . . . . . . . . . . $\pm \mathrm{V}_{\mathrm{S}}$
$\mathbf{R}_{\mathrm{IN}}, \mathrm{R}_{\mathrm{FB}}$ Pins . . . . . . . . . . . . . . . . . . . . . . . $\pm \mathrm{V}_{\mathrm{S}}$
Storage Temperature . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering) . . . . . . . . . . . . . $300^{\circ} \mathrm{C}$
Output Short Circuit to Ground Indefinite
TTL Logic Reference Short Indefinite Circuit to Ground


Figure 1. Sample-to-Hold Offset vs. Logic Level (HOLD Active)


Figure 2. Acquisition Time vs. Hold Capacitance (10V Step to 0.01\%)


Figure 3. Large Signal Response, Sample Mode


Figure 4. Sample-to-Hold Settling Time ( $\overline{H O L D}$ Active)


Figure 5. DIP Pin Configuration


Figure 6. Connection Diagram, Gain $=+1, \overline{H O L D}$ Active


Figure 7. Connection Diagram, Gain $=+2, \overline{H O L D}$ Active


Figure 8. Connection Diagram, Gain $=-1, \overline{H O L D}$ Active

FEATURES
Four Matched Sample-and-Hold Amplifiers Independent Inputs, Outputs and Control Pins 500ns Hold Mode Settling
1 $\boldsymbol{\mu s}$ Maximum Acquisition Time to 0.01\%
Low Droop Rate: $0.01 \mu \mathrm{~V} / \mu \mathrm{s}$
Internal Hold Capacitors
75ps Maximum Aperture Jitter
Low Power Dissipation: 430mW
0.3" Skinny DIP Package

MIL-STD-883 Compliant Versions Available

## PRODUCT DESCRIPTION

The AD684 is a monolithic quad sample-and-hold amplifier (SHA). It features four complete sampling channels, each controlled by an independent hold command. Each SHA is complete with an internal hold capacitor. The high accuracy SHA channels are self-contained and require no external components or adjustments. The AD684 is manufactured on a BiMOS process which provides a merger of high performance bipolar circuitry and low power CMOS logic.

The AD684 is ideal for high performance, multichannel data acquisition systems. Each SHA channel can acquire a signal in less than $1 \mu \mathrm{~s}$ and retain the held value with a droop rate of less than $0.01 \mu \mathrm{~V} / \mu \mathrm{s}$. Excellent linearity and ac performance make the AD684 an ideal front end for high speed 12- and 14-bit ADCs.
The AD684 has a self-correcting architecture that minimizes hold mode errors and insures accuracy over temperature. Each channel of the AD684 is capable of sourcing 5 mA and incorporates output short circuit protection.
The AD684 is specified for three temperature ranges. The J grade device is specified for operation from 0 to $70^{\circ} \mathrm{C}$, the A grade from $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ and the S grade from $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.

FUNCTIONAL BLOCK DIAGRAM


## PRODUCT HIGHLIGHTS

1. Fast acquisition time ( $1 \mu \mathrm{~s}$ ) and low aperture jitter ( 75 ps ) make the AD684 the best choice for multiple channel data acquisition systems.
2. Monolithic construction insures excellent interchannel matching in terms of timing and accuracy, as well as high reliability.
3. Independent inputs, outputs and sample-and-hold controls allow user flexibility in system architecture.
4. Low droop $(0.01 \mu \mathrm{~V} / \mu \mathrm{s})$ and internally compensated hold mode error results in superior system accuracy.
5. The AD684's fast settling time and low output impedance make it ideal for driving high speed analog to digital converters such as the AD578, AD674, AD7572 and the AD7672.
6. The AD684 is available in versions compliant with MIL-STD-883. Refer to the Analog Devices Military Products Databook or current AD684/883B data sheet for detailed specifications.

| Parameter | AD684J |  |  | AD684A |  |  | AD684S |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min |  | Max | Min | Typ | Max | Min | Typ | Max |  |
| SAMPLING CHARACTERISTICS |  |  |  |  |  |  |  |  |  |  |
| Acquisition Time |  |  |  |  |  |  |  |  |  |  |
| 10 V Step to $0.01 \%$ |  | 0.75 | 1.0 |  | 0.75 | 1.0 |  | 0.75 | 1.0 |  |
| 10 V Step to 0.1\% |  | 0.5 | 0.6 |  | 0.5 | 0.6 |  | 0.5 | 0.6 | $\mu \mathrm{s}$ |
| Small Signal Bandwidth |  | 4 |  |  | 4 |  |  | 4 |  | MHz |
| Full Power Bandwidth |  | 1 |  |  | 1 |  |  | 1 |  | MHz |
| HOLD CHARACTERISTICS |  |  |  |  |  |  |  |  |  |  |
| Effective Aperture Delay | -35 | -25 | -15 | -35 | -25 | -15 | -35 | -25 | -15 | ns |
| Aperture Jitter |  | 50 | 75 |  | 50 | 75 |  | 50 | 75 | ps |
| Hold Settling Time (to 1 mV ) |  | 250 | 500 |  | 250 | 500 |  | 250 | 500 |  |
| Droop Rate ${ }^{1}$ |  | 0.01 | 1 |  | 0.01 | 1 |  | 0.01 | 1 | $\mu \mathrm{V} / \mu^{\mathrm{s}}$ |
| Feedthrough |  |  |  |  |  |  |  |  |  |  |
| ACCURACY CHARACTERISTICS ${ }^{1}$ |  |  |  |  |  |  |  |  |  |  |
| Hold Mode Offset | -4 | -1 | +3 | -4 | -1 | +3 | -4 | -1 | +3 | mV |
| Hold Mode Offset Drift |  | 10 |  |  | 10 |  |  | 10 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Sample Mode Offset |  | 50 | 200 |  | 50 | 200 |  | 50 | 200 | mV |
| Nonlinearity |  | $\pm 0.002$ | $\pm 0.003$ |  | $\pm 0.002$ | $\pm 0.003$ |  | $\pm 0.003$ | $\pm 0.005$ | \% FS |
| Gain Error |  | $\pm 0.03$ | $\pm 0.05$ |  | $\pm 0.03$ | $\pm 0.05$ |  | $\pm 0.03$ | $\pm 0.05$ | \% FS |
| INTERCHANNEL CHARACTERISTICS |  |  |  |  |  |  |  |  |  |  |
| Interchannel Isolation |  |  |  |  |  |  |  |  |  |  |
| Interchannel Aperture Offset |  | 150 | 300 |  | 150 | 300 |  | 150 | 300 | ps |
| Interchannel Offset |  | 0.4 | 1.5 |  | 0.4 | 2.0 |  | 0.4 | 2.0 | mV |
| OUTPUT CHARACTERISTICS |  |  |  |  |  |  |  |  |  |  |
| Output Drive Current ${ }^{2}$ | -5 |  | +5 | -5 |  | +5 | -5 |  | +5 | mA |
| Output Resistance, dc |  | 0.3 | 0.5 |  | 0.3 | 0.5 |  | 0.3 | 0.5 |  |
| Total Output Noise |  |  |  |  |  |  |  |  |  |  |
| (dc to 5 MHz ) |  | 150 |  |  | 150 |  |  | 150 |  | $\mu \mathrm{V}$ rms |
| Sampled dc Uncertainty |  | 85 |  |  | 85 |  |  | 85 |  | $\mu \mathrm{V}$ rms |
| Hold Mode Noise |  |  |  |  |  |  |  |  |  |  |
| Short Circuit Current ${ }^{3}$ |  |  |  |  |  |  |  |  |  |  |
| Source |  | 20 |  |  | 20 |  |  | 20 |  | mA |
| Sink |  | 10 |  |  | 10 |  |  | 10 |  | mA |
|  |  |  |  |  |  |  |  |  |  |  |
| Input Voltage Range | -5 |  | +5 | -5 |  | +5 | -5 |  | +5 | V |
| Bias Current ${ }^{4}$ |  | 100 | 250 |  | 100 | 250 |  | 100 | 250 | nA |
|  |  |  | 400 |  |  | 500 |  |  | 500 | nA |
| Input Impedance |  | 50 |  |  | 50 |  |  | 50 |  | $\mathrm{M} \Omega$ |
| Input Capacitance |  | 2 |  |  | 2 |  |  | 2 |  | pF |
|  |  |  |  |  |  |  |  |  |  |  |
|  |  |  |  |  |  |  |  |  |  |  |  |
| Input Voltage High | 2.0 |  |  | 2.0 |  |  | 2.0 |  |  | V |
| Input Current ( $\mathrm{V}_{\text {IN }}=5 \mathrm{~V}$ ) |  | 2 | 10 |  | 2 | 10 |  | 2 | 10 | $\mu \mathrm{A}$ |
| POWER SUPPLY CHARACTERISTICS |  |  |  |  |  |  |  |  |  |  |
| Operating Voltage Range ( $\mathrm{V}_{\mathrm{CC}}, \mathrm{V}_{\mathrm{EE}}$ ) | $\pm 10.8$ | $\pm 12$ | $\pm 13.2$ | $\pm 10.8$ | $\pm 12$ | $\pm 13.2$ | $\pm 10.8$ | $\pm 12$ | $\pm 13.2$ |  |
| Supply Current |  | 18 | 25 |  | 18 | 25 |  | 18 | 26 | mA |
| + PSRR | 65 | 70 |  | 65 | 70 |  | 65 | 70 |  | dB |
| -PSRR | 60 | 65 |  | 60 | 65 |  | 60 | 65 |  | dB |
| Power Consumption |  | 430 | 600 |  | 430 | 600 |  | 430 | 625 | mW |
| TEMPERATURE RANGE |  |  |  |  |  |  |  |  |  |  |
| PACKAGE OPTIONS <br> 16-Pin Cerdip (Q) |  |  |  |  |  |  |  |  |  |  |
|  |  |  |  |  |  |  |  |  |  |  |  |

## NOTES

[^84]ABSOLUTE MAXIMUM RATINGS*

| Spec | With Respect to | Min | Max | Unit |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{cc}}$ | Common | -0.3 | +15 | V |
| $\mathrm{V}_{\text {EE }}$ | Common | -15 | +0.3 | V |
| Control Inputs | Common | -0.5 | +7 | V |
| Analog Inputs | Common | -12 | +12 | V |
| Output Short Circuit to Ground, $\mathrm{V}_{\mathrm{CC}}$, or $\mathrm{V}_{\mathrm{EE}}$ |  | Indefinite |  |  |
| Max Junction Temperature |  |  | +175 | ${ }^{\circ} \mathrm{C}$ |
| Storage |  | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |
| Lead Temperature (10sec max) |  |  | +300 | ${ }^{\circ} \mathrm{C}$ |
| Power Dissipation |  |  | 640 | mW |


*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied.

## CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts.

ORDERING GUIDE

| Model $^{\mathbf{1}}$ | Temperature Range | Package <br> Option $^{2}$ |
| :--- | :--- | :--- |
| AD684JQ | 0 to $+70^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| AD684AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Q-16 |
| AD684SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |

## NOTES

${ }^{1}$ For details on grade and package offerings screened in accordance with MIL-STD-883, refer to the Analog Devices Military Products Databook or current AD684/883B data sheet.
${ }^{2} Q=$ Cerdip. For outline information see Package Information section.

FEATURES
Acquisition Time to 0.01\%: $\mathbf{7 0 0}$ ns Maximum
Low Power Dissipation: 95 mW
Low Droop Rate: $0.01 \mu \mathrm{~V} / \mu \mathrm{s}$
Fully Specified and Tested Hold Mode Distortion
Total Harmonic Distortion: $\mathbf{- 8 0} \mathbf{d B}$ Maximum
Aperture Jitter: 75 ps Maximum
Internal Hold Capacitor
Self-Correcting Architecture
8-Pin Mini Cerdip and Plastic Package
MIL-STD-883 Compliant Versions Available

## FUNCTIONAL BLOCK DIAGRAM

## PRODUCT HIGHLIGHTS

1. Fast acquisition time ( 700 ns ), low aperture jitter ( 75 ps ) and fully specified hold mode distortion make the AD781 an ideal SHA for sampling systems.
2. Low droop ( $0.01 \mu \mathrm{~V} / \mu \mathrm{s}$ ) and internally compensated hold mode error results in superior system accuracy.
3. Low power ( 95 mW typical), complete functionality and small size make the AD781 an ideal choice for a variety of high performance, low power applications.
4. The AD781 requires no external components or adjustments.
5. Excellent choice as a front-end SHA for high speed analog-to-digital converters such as the AD671, AD7586, AD674B, AD774B, AD7572 and AD7672.
6. Fully specified and tested hold mode distortion guarantees the performance of the SHA in sampled data systems.
7. The AD781 is available in versions compliant with MIL-STD-883. Refer to the Analog Devices Military Products Databook or current AD781/883B data sheet for detailed specifications.


This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

## PRODUCT DESCRIPTION

The AD781 is a high speed monolithic sample-and-hold amplifier (SHA). The AD781 guarantees a maximum acquisition time of 700 ns to $0.01 \%$ over temperature. The AD781 is specified and tested for hold mode total harmonic distortion and hold mode signal-to-noise and distortion. The AD781 is configured as a unity gain amplifier and uses a self-correcting architecture that minimizes hold mode errors and insures accuracy over temperatare. The AD781 is self-contained and requires no external components or adjustments.

The low power dissipation, 8-pin mini-DIP package and completeness make the AD781 ideal for highly compact board layouts. The AD781 will acquire a full-scale input in less than 700 ns and retain the held value with a droop rate of $0.01 \mu \mathrm{~V} / \mu \mathrm{s}$. Excellent linearity and hold mode dc and dynamic performance make the AD781 ideal for 12- and 14-bit high speed analog-to-digital converters.

The AD781 is manufactured on Analog Devices' BiMOS process which merges high performance, low noise bipolar circuitry with low power CMOS to provide an accurate, high speed, low power SHA.
The AD781 is specified for three temperature ranges. The J grade device is specified for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$, the A grade from $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ and the S grade from $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. The J and A grades are available in 8-pin plastic DIP packages. The $S$ grade is available in an 8 -pin cerdip package.
${ }^{*}$ Protected by U.S. Patent No. 4,962,325.


## AD781 - SPECIFICATIONS

DC SPECIFICATIONS ( $T_{\min }$ to $T_{\max }$ with $V_{C C}=+12 V \pm 10 \%, V_{E E}=-12 V \pm 10 \%, C_{L}=20 \mathrm{pF}$, unless otherwise specified)

| Parameter | AD781J |  |  | AD781A |  |  | AD781S |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| SAMPLING CHARACTERISTICS |  |  |  |  |  |  |  |  |  |  |
| Acquisition Time |  |  |  |  |  |  |  |  |  |  |
| 10 V Step to $0.01 \%$ |  | 600 | 700 |  | 600 | 700 |  | 600 | 700 | ns |
| 10 V Step to $0.1 \%$ |  | 500 | 600 |  | 500 | 600 |  | 500 | 600 | ns |
| Small Signal Bandwidth |  | 4 |  |  | 4 |  |  | 4 |  | MHz |
| Full Power Bandwidth |  | 1 |  |  | 1 |  |  | 1 |  | MHz |
| HOLD CHARACTERISTICS |  |  |  |  |  |  |  |  |  |  |
| Effective Aperture Delay ( $25^{\circ} \mathrm{C}$ ) | -35 | -25 | -15 | -35 | -25 | -15 | -35 | -25 | -15 | ns |
| Aperture Jitter ( $25^{\circ} \mathrm{C}$ ) |  | 50 | 75 |  | 50 | 75 |  | 50 | 75 | ps |
| Hold Settling (to $1 \mathrm{mV}, 25^{\circ} \mathrm{C}$ ) |  | 250 | 500 |  | 250 | 500 |  | 250 | 500 |  |
| Droop Rate |  | 0.01 | 1 |  | 0.01 | 1 |  | 0.01 | 1 | $\mu \mathrm{V} / \mu \mathrm{s}$ |
| Feedthrough ( $25^{\circ} \mathrm{C}$ ) |  | -86 |  |  | -86 |  |  | -86 |  | dB |
| ACCURACY CHARACTERISTICS ${ }^{1}$ |  |  |  |  |  |  |  |  |  |  |
| Hold Mode Offset | -4 | -1 | +3 | -4 | -1 | +3 | -4 | -1 | +3 |  |
| Hold Mode Offset Drift |  | 10 |  |  | 10 |  |  | 10 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Sample Mode Offset |  | 50 | 200 |  | 50 | 200 |  | 50 | 200 | mV |
| Nonlinearity |  | $\pm 0.002$ | $\pm 0.003$ |  | $\pm 0.002$ | $\pm 0.003$ |  | $\pm 0.003$ | $\pm 0.005$ | \% FS |
| Gain Error |  | $\pm 0.01$ | $\pm 0.025$ |  | $\pm 0.01$ | $\pm 0.025$ |  | $\pm 0.01$ | $\pm 0.025$ | \% FS |
| OUTPUT CHARACTERISTICS |  |  |  |  |  |  |  |  |  |  |
| Output Drive Current | -5 |  | +5 | -5 |  | +5 | -5 |  | +5 | mA |
| Output Resistance, DC |  | 0.3 | 0.5 |  | 0.3 | 0.5 |  | 0.3 | 0.5 |  |
| Total Output Noise (DC to 5 MHz ) |  | 150 |  |  | 150 |  |  | 150 |  | $\mu \mathrm{V}$ rms |
| Sampled DC Uncertainty |  | 85 |  |  | 85 |  |  | 85 |  | $\mu \mathrm{V}$ rms |
| Hold Mode Noise (DC to 5 MHz ) |  | 125 |  |  | 125 |  |  | 125 |  | $\mu \mathrm{V}$ rms |
| Short Circuit Current |  |  |  |  |  |  |  |  |  |  |
| Source |  | 20 |  |  | 20 |  |  | 20 |  | mA |
| Sink |  | 10 |  |  | 10 |  |  | 10 |  | mA |
| INPUT CHARACTERISTICS |  |  |  |  |  |  |  |  |  |  |
| Input Voltage Range | -5 |  | +5 | -5 |  | +5 | -5 |  | +5 | V |
| Bias Current |  | 50 | 250 |  | 50 | 250 |  | 50 | 250 | nA |
| Input Impedance |  | 50 |  |  | 50 |  |  | 50 |  | $\mathrm{M} \Omega$ |
| Input Capacitance |  | 2 |  |  | 2 |  |  | 2 |  | pF |
| DIGITAL CHARACTERISTICS |  |  |  |  |  |  |  |  |  |  |
| Input Voltage Low |  |  | 0.8 |  |  | 0.8 |  |  | 0.8 | V |
| Input Voltage High | 2.0 |  |  | 2.0 |  |  | 2.0 |  |  | V |
| Input Current High ( $\mathrm{V}_{\text {IN }}=5 \mathrm{~V}$ ) |  | 2 | 10 |  | 2 | 10 |  | 2 | 10 | $\mu \mathrm{A}$ |
| POWER SUPPLY CHARACTERISTICS |  |  |  |  |  |  |  |  |  |  |
| Operating Voltage Range | $\pm 10.8$ | $\pm 12$ | $\pm 13.2$ | $\pm 10.8$ | $\pm 12$ | $\pm 13.2$ | $\pm 10.8$ | $\pm 12$ | $\pm 13.2$ | V |
| Supply Current |  | 4 | 6.5 |  | 4 | 6.5 |  | 4 | 7 | mA |
| +PSRR (+12 V $\pm 10 \%$ ) | 70 | 80 |  | 70 | 80 |  | 70 | 80 |  | dB |
| -PSRR (-12 V $\pm 10 \%$ ) | 65 | 75 |  | 65 | 75 |  | 65 | 75 |  | dB |
| Power Consumption |  | 95 | 175 |  | 95 | 175 |  | 95 | 185 | mW |
| TEMPERATURE RANGE <br> Specified Performance | 0 |  | +70 | -40 |  | +85 | -55 |  | +125 | ${ }^{\circ} \mathrm{C}$ |

## NOTE

${ }^{1}$ Specified and tested over an input range of $\pm 5 \mathrm{~V}$.
Specifications subject to change without notice.
Specifications shown in boldface are tested on all devices at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed although only those shown in boldface are tested.

HOLD MODE AC SPECIFICATIONS $\begin{aligned} & \left(T_{\min } \text { to } T_{\max }, V_{c c}=+12 V \pm 10 \%, V_{E E}=-12 \mathrm{~V} \pm 10 \%, C_{\mathrm{L}}=20 \mathrm{pF} \text {, }, \text { iess otherwise specified }\right)^{1}\end{aligned}$

| Parameter | AD781J |  | AD781A |  | AD781S |  |  |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Typ |  |  |  |  |  |  |  |
| Typ | Max | Min | Typ | Max | Min | Typ | Max | Units

NOTE
${ }^{1} \mathrm{~F}_{\text {IN }}$ amplitude $=0 \mathrm{~dB}$ and $\mathrm{F}_{\text {SAMPLE }}=500 \mathrm{kHz}$ unless otherwise indicated.
Specifications shown in boldface are tested on all devices at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed although only those shown in boldface are tested.

## ABSOLUTE MAXIMUM RATINGS*

| Spec | With Respect to | Min | Max | Unit |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {CC }}$ | Common | -0.3 | +15 | V |
| $\mathrm{V}_{\text {EE }}$ | Common | -15 | +0.3 | V |
| Control Input | Common | -0.5 | +7 | V |
| Analog Input | Common | -12 | +12 | V |
| Output Short Circuit to Ground, $\mathrm{V}_{\mathrm{CC}}$, or $\mathrm{V}_{\mathrm{EE}}$ |  | Indefinite |  |  |
| Maximum Junction Temperature |  |  | +175 | ${ }^{\circ} \mathrm{C}$ |
| Storage |  | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |
| Lead Temperature ( 10 sec max ) |  |  | +300 | ${ }^{\circ} \mathrm{C}$ |
| Power Dissipation |  |  | 195 | mW |

*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied.

## PIN CONFIGURATION



## ORDERING GUIDE

| Model $^{\mathbf{1}}$ | Temperature <br> Range | Description | Package <br> Options |
| :--- | :--- | :--- | :--- |
| AD781JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | N-8 |
| AD781AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | N-8 |
| AD781SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Cerdip | Q-8 |

## NOTES

${ }^{1}$ For details on grade and package offerings screened in accordance with MIL-STD-883, refer to the Analog Devices Military Products Databook or current AD781/883B data sheet.
${ }^{2} \mathbf{N}=$ Plastic DIP; $\mathrm{Q}=$ Cerdip. For outline information see Package Information section.

## CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts.


FEATURES
Acquisition Time to 0.01\%: 250 ns Typical
Low Power Dissipation: 95 mW
Low Droop Rate: $0.02 \mu \mathrm{~V} / \mu \mathrm{s}$
Fully Specified and Tested Hold Mode Distortion
Total Harmonic Distortion: - $\mathbf{8 5} \mathbf{~ d B}$
Aperture Jitter: $\mathbf{5 0}$ ps Maximum
Internal Hold Capacitor
Self-Correcting Architecture
8-Pin Mini Cerdip and SOIC Packages

FUNCTIONAL BLOCK DIAGRAM


## PRODUCT HIGHLIGHTS

1. Fast acquisition time ( 250 ns ), low aperture jitter ( 20 ps ) and fully specified hold mode distortion make the AD783 an ideal SHA for sampling systems.
2. Low droop $(0.02 \mu \mathrm{~V} / \mu \mathrm{s})$ and internally compensated hold mode error result in superior system accuracy.
3. Low power ( 95 mW typical), complete functionality and small size make the AD783 an ideal choice for a variety of high performance applications.
4. The AD783 requires no external components or adjustments.
5. The AD783 is an excellent choice as a front-end SHA for high speed analog-to-digital converters such as the AD671, AD7586, AD674B, AD774B, AD7572 and AD7672.
6. Fully specified and tested hold mode distortion guarantees the performance of the SHA in sampled data systems.

DC SPECIFICATIONS ( $\mathrm{T}_{\text {mis }}$ to $\mathrm{T}_{\text {mxx }}$ with $\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V} \pm 5 \%, \mathrm{~V}_{\mathrm{EE}}=-5 \mathrm{~V} \pm 5 \%, \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$, unless otherwise noted)

| Parameter | Min | AD783J/A Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: |
| SAMPLING CHARACTERISTICS <br> Acquisition Time <br> 5 V Step to $0.01 \%$ <br> 5 V Step to $0.1 \%$ <br> Small Signal Bandwidth <br> Full Power Bandwidth |  | $\begin{aligned} & 250 \\ & 200 \\ & 15 \\ & 2 \end{aligned}$ | $\begin{aligned} & 375 \\ & 350 \end{aligned}$ | ns <br> $\mathrm{MH}_{2}$ <br> MHz |
| HOLD CHARACTERISTICS <br> Effective Aperture Delay ( $+25^{\circ} \mathrm{C}$ ) <br> Aperture Jitter ( $+25^{\circ} \mathrm{C}$ ) <br> Hold Settling (to $1 \mathrm{mV},+25^{\circ} \mathrm{C}$ ) <br> Droop Rate <br> Feedthrough $\left(+25^{\circ} \mathrm{C}\right)$ $\left(\mathrm{V}_{\mathrm{IN}}= \pm 2.5 \mathrm{~V}, 500 \mathrm{kHz}\right)$ | -30 | $\begin{aligned} & 15 \\ & 20 \\ & 150 \\ & 0.02 \\ & \\ & -80 \end{aligned}$ | $\begin{aligned} & 30 \\ & 50 \\ & 200 \\ & 1 \end{aligned}$ | ns <br> ps <br> ns <br> $\mu \mathrm{V} / \mu \mathrm{s}$ <br> dB |
| ACCURACY CHARACTERISTICS ${ }^{1}$ <br> Hold Mode Offset <br> Hold Mode Offset Drift <br> Sample Mode Offset <br> Nonlinearity <br> Gain Error | -5 | $\begin{aligned} & 0 \\ & 10 \\ & 50 \\ & \pm 0.005 \\ & \pm 0.03 \end{aligned}$ | $\begin{aligned} & +5 \\ & 200 \\ & \pm 0.1 \end{aligned}$ | mV <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ <br> mV <br> \% FS <br> \% FS |
| OUTPUT CHARACTERISTICS <br> Output Drive Current <br> Output Resistance, DC <br> Total Output Noise (DC to 5 MHz ) <br> Sampled DC Uncertainty <br> Hold Mode Noise (DC to 5 MHz ) <br> Short Circuit Current <br> Source <br> Sink | -5 | $\begin{aligned} & 0.3 \\ & 150 \\ & 85 \\ & 125 \end{aligned}$ | $\begin{aligned} & +5 \\ & 0.6 \end{aligned}$ $\begin{aligned} & 20 \\ & 13 \end{aligned}$ | mA <br> $\Omega$ <br> $\mu \mathrm{V}$ rms <br> $\mu \mathrm{V}$ rms <br> $\mu \mathrm{V}$ rms <br> mA <br> mA |
| INPUT CHARACTERISTICS <br> Input Voltage Range <br> Bias Current <br> Input Impedance Input Capacitance | -2.5 | $\begin{aligned} & 100 \\ & 10 \\ & 2 \end{aligned}$ | $\begin{aligned} & +250 \\ & \end{aligned}$ | V <br> nA <br> $\mathrm{M} \Omega$ <br> pF |
| DIGITAL CHARACTERISTICS <br> Input Voltage Low Input Voltage High Input Current High ( $\mathrm{V}_{\text {IN }}=5 \mathrm{~V}$ ) | 2.0 | 2 | $\begin{aligned} & 0.8 \\ & 10 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mu \mathrm{~A} \end{aligned}$ |
| POWER SUPPLY CHARACTERISTICS <br> Operating Voltage Range <br> Supply Current <br> $+\operatorname{PSRR}(+5 \mathrm{~V} \pm 5 \%)$ <br> $-\operatorname{PSRR}(-5 \mathrm{~V} \pm 5 \%)$ <br> Power Consumption | $\begin{aligned} & \pm 4.75 \\ & 45 \\ & 45 \end{aligned}$ | $\begin{aligned} & \pm 5 \\ & 9.5 \\ & 65 \\ & 65 \\ & 95 \end{aligned}$ | $\begin{aligned} & \pm 5.25 \\ & 17 \end{aligned}$ <br> 175 | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~mA} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \\ & \mathrm{~mW} \end{aligned}$ |
| TEMPERATURE RANGE Specified Performance | ${ }_{-40}$ |  | $\begin{aligned} & +70 \\ & +85 \end{aligned}$ | $\begin{aligned} & { }^{\circ} \mathrm{C} \\ & { }^{\circ} \mathrm{C} \end{aligned}$ |

## NOTE

${ }^{1}$ Specified and tested over an input range of $\pm 2.5 \mathrm{~V}$.
Specifications subject to change without notice.

HOLD MODE AC SPECIFICATIONS $\begin{aligned} & \left(T_{M I N} \text { to } T_{\text {max }} \text { with } V_{\text {EC }}=+5 V \pm 5 \%,\right. \\ & \left.V_{E E}=-5 V \pm 5 \%, C_{L}=50 \mathrm{pF} \text {, unless otherwise noted) }\right)^{1}, ~\end{aligned}$

| Parameter | Min | AD783J/A <br> Typ | Max |
| :--- | :---: | :---: | :---: |
| TOTAL HARMONIC DISTORTION |  |  | Units |
| $\mathrm{f}_{\text {IN }}=100 \mathrm{kHz}$ | -85 | -80 |  |
| $\mathrm{f}_{\text {IN }}=500 \mathrm{kHz}$ | -72 | dB |  |
| SIGNAL-TO-NOISE AND DISTORTION |  | dB |  |
| $\mathrm{f}_{\mathrm{IN}}=100 \mathrm{kHz}$ | 77 | dB |  |
| $\mathrm{f}_{\mathrm{IN}}=500 \mathrm{kHz}$ | 70 | dB |  |
| INTERMODULATION DISTORTION |  |  |  |
| (F1 =99 kHz, F2 $=100 \mathrm{kHz}$ ) | -80 | dB |  |
| Second Order Products | -85 | dB |  |
| Third Order Products |  |  |  |

## NOTE

${ }^{1} \mathrm{f}_{\text {IN }}$ amplitude $=0 \mathrm{~dB}$ and $\mathrm{f}_{\text {SAMPLE }}=300 \mathrm{kHz}$ unless otherwise indicated.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS*

| Spec | With <br> Respect to | Min | Max | Units |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | COM | -0.5 | +6.5 | V |
| $\mathrm{V}_{\text {EE }}$ | COM | -6.5 | +0.5 | V |
| Analog Input | COM | -6.5 | +6.5 | V |
| Digital Input | COM | -0.5 | +6.5 | V |
| Output Short Circuit to Ground, $\mathrm{V}_{\mathrm{CC}}$, or $\mathrm{V}_{\mathrm{EE}}$ |  | Indefinite |  |  |
| Maximum Junction Temperature |  |  | +175 | ${ }^{\circ} \mathrm{C}$ |
| Storage |  | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |
| Lead Temperature ( 10 sec max ) |  |  | +300 | ${ }^{\circ} \mathrm{C}$ |

*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied.

PIN CONFIGURATION


## CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts.

## ORDERING GUIDE

| Model $^{\mathbf{1}}$ | Temperature <br> Range | Description | Package <br> Options |
| :--- | :--- | :--- | :--- |
| AD783JQ | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin Cerdip | Q-8 |
| AD783AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Cerdip | Q-8 |
| AD783JR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin SOIC | R-8 |
| AD783AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin SOIC | R-8 |

## NOTES

${ }^{1}$ For details on grade and package offerings screened in accordance with MIL-STD-883, refer to the Analog Devices Military Products Databook or current AD783/883B data sheet.
${ }^{2} \mathrm{Q}=$ Cerdip, $\mathrm{R}=$ SOIC. For outline information see Package Information section.

## Typical Characteristics-AD783



Power Supply Rejection Ratio vs. Frequency


Bias Current vs. Input Voltage


Droop Rate vs. Temperature, $V_{I N}=0 \mathrm{~V}$


Acquisition Time (to 0.01\%) vs. Input Step Size

## DEFINITIONS OF SPECIFICATIONS

Acquisition Time-The length of time that the SHA must remain in the sample mode in order to acquire a full-scale input step to a given level of accuracy.
Small Signal Bandwidth - The frequency at which the held output amplitude is 3 dB below the input amplitude, under an input condition of a 100 mV p-p sine wave.
Full Power Bandwidth - The frequency at which the held output amplitude is 3 dB below the input amplitude, under an input condition of a 5 V p-p sine wave.
Effective Aperture Delay-The difference between the switch delay and the analog delay of the SHA channel. A negative number indicates that the analog portion of the overall delay is greater than the switch portion. This effective delay represents the point in time, relative to the hold command, that the input signal will be sampled.
Aperture Jitter-The variations in aperture delay for successive samples. Aperture jitter puts an upper limit on the maximum frequency that can be accurately sampled.
Hold Settling Time-The time required for the output to settle to within a specified level of accuracy of its final held value after the hold command has been given.
Droop Rate-The drift in output voltage while in the hold mode.
Feedthrough - The attenuated version of a changing input signal that appears at the output when the SHA is in the hold mode.
Hold Mode Offset - The difference between the input signal and the held output. This offset term applies only in the hold mode and includes the error caused by charge injection and all other internal offsets. It is specified for an input of 0 V .
Sample Mode Offset-The difference between the input and output signals when the SHA is in the sample mode.
Nonlinearity - The deviation from a straight line on a plot of input vs. (held) output as referenced to a straight line drawn between endpoints, over an input range of -2.5 V and +2.5 V .
Gain Error-Deviation from a gain of +1 on the transfer function of input vs. held output.
Power Supply Rejection Ratio-A measure of change in the held output voltage for a specified change in the positive or negative supply.
Sampled DC Uncertainty-The internal rms SHA noise that is sampled onto the hold capacitor.
Hold Mode Noise-The rms noise at the output of the SHA while in the hold mode, specified over a given bandwidth.
Total Output Noise-The total rms noise that is seen at the output of the SHA while in the hold mode. It is the rms summation of the sampled dc uncertainty and the hold mode noise.

Output Drive Current-The maximum current the SHA can source (or sink) while maintaining a change in hold mode offset of less than 2.5 mV .
Signal-To-Noise and Distortion ( $\mathbf{S} / \mathbf{N}+\mathbf{D}$ ) Ratio-S/N+D is the ratio of the rms value of the measured input signal to the rms sum of all other spectral components below the Nyquist frequency, including harmonics but excluding dc. The value for $\mathrm{S} / \mathrm{N}+\mathrm{D}$ is expressed in decibels.
Total Harmonic Distortion (THD)-THD is the ratio of the rms sum of the first six harmonic components to the rms value of the measured input signal and is expressed in decibels.

Intermodulation Distortion (IMD)-With inputs consisting of sine waves at two frequencies, fa and fb , any device with nonlinearities will create distortion products, of order ( $m+n$ ), at sum and difference frequency of $\mathrm{mfa} \pm \mathrm{nfb}$, where $\mathrm{m}, \mathrm{n}=0,1,2$, 3 . . . . Intermodulation terms are those for which m or n is not equal to zero. For example, the second order terms are ( $\mathrm{fa}+\mathrm{fb}$ ) and $(f a-f b)$, and the third order terms are $(2 f a+f b),{ }^{\prime}(2 f a-f b)$, $(\mathrm{fa}+2 \mathrm{fb})$ and $(\mathrm{fa}-2 \mathrm{fb})$. The IMD products are expressed as the decibel ratio of the rms sum of the measured input signals to the rms sum of the distortion terms. The two signals are of equal amplitude, and peak value of their sums is -0.5 dB from full scale. The IMD products are normalized to a 0 dB input signal.

## FUNCTIONAL DESCRIPTION

The AD783 is a complete, high speed sample-and-hold amplifier that provides high speed sampling to 12-bit accuracy in 250 ns .

The AD783 is completely self-contained, including an on-chip hold capacitor, and requires no external components or adjustments to perform the sampling function. Both input and output are treated as a single-ended signal, referred to common.
The AD783 utilizes a proprietary circuit design which includes a self-correcting architecture. This sample-and-hold circuit corrects for internal errors after the hold command has been given, by compensating for amplifier gain and offset errors, and charge injection errors. Due to the nature of the design, the SHA output in the sample mode is not intended to provide an accurate representation of the input. However, in hold mode, the internal circuitry is reconfigured to produce an accurately held version of the input signal. Below is a block diagram of the AD783.


## DYNAMIC PERFORMANCE

The AD783 is compatible with 12-bit A-to-D converters in terms of both accuracy and speed. The fast acquisition time, fast hold settling time and good output drive capability allow the AD783 to be used with high speed, high resolution A-to-D converters like the AD671 and AD7586. The AD783's fast acquisition time provides high throughput rates for multichannel data acquisition systems. Typically, the AD783 can acquire a 5 V step in less than 250 ns . Figure 1 shows the settling accuracy as a function of acquisition time.


Figure 1. $V_{\text {Out }}$ Settling vs. Acquisition Time
The hold settling determines the required time, after the hold command is given, for the output to settle to its final specified accuracy. The typical settling behavior of the AD783 is 150 ns . The settling time of the AD783 is sufficiently fast to allow the SHA, in most cases, to directly drive an A-to-D converter without the need for an added "start convert" delay.

## HOLD MODE OFFSET

The dc accuracy of the AD783 is determined primarily by the hold mode offset. The hold mode offset refers to the difference between the final held output voltage and the input signal at the time the hold command is given. The hold mode offset arises from a voltage error introduced onto the hold capacitor by charge injection of the internal switches. The nominal hold mode offset is specified for a 0 V input condition. Over the input range of -2.5 V to +2.5 V , the AD783 is also characterized for an effective gain error and nonlinearity of the held value, as shown in Figure 2. As indicated by the AD783 specifications, the hold mode offset is very stable over temperature.


Figure 2. Hold Mode Offset, Gain Error and Nonlinearity
For applications where it is important to obtain zero offset, the hold mode offset may be nulled externally at the input to the A-to-D converter. Adjustment of the offset may be accomplished through the A-to-D itself or by an external amplifier with offset nulling capability (e.g., AD711). The offset will change less than 0.5 mV over the specified temperature range.

## SUPPLY DECOUPLING AND GROUNDING CONSIDERATIONS

As with any high speed, high resolution data acquisition system, the power supplies should be well regulated and free from excessive high frequency noise (ripple). The supply connection to the AD783 should also be capable of delivering transient currents to the device. To achieve the specified accuracy and dynamic performance, decoupling capacitors must be placed directly at both the positive and negative supply pins to common. Ceramic type $0.1 \mu \mathrm{~F}$ capacitors should be connected from $\mathrm{V}_{\mathrm{CC}}$ and $\mathrm{V}_{\mathrm{EE}}$ to common.


Figure 3. Basic Grounding and Decoupling Diagram

The AD783 does not provide separate analog and digital ground leads as is the case with most A-to-D converters. The common pin is the single ground terminal for the device. It is the reference point for the sampled input voltage and the held output voltage and also the digital ground return path. The common pin should be connected to the reference (analog) ground of the A-to-D converter with a separate ground lead. Since the analog and digital grounds in the AD783 are connected internally, the common pin should also be connected to the digital ground, which is usually tied to analog common at the A-to-D converter. Figure 3 illustrates the recommended decoupling and grounding practice.

## NOISE CHARACTERISTICS

Designers of data conversion circuits must also consider the effect of noise sources on the accuracy of the data acquisition system. A sample-and-hold amplifier that precedes the A-to-D converter introduces some noise and represents another source of uncertainty in the conversion process. The noise from the AD783 is specified as the total output noise, which includes both the sampled wideband noise of the SHA in addition to the band limited output noise. The total output noise is the rms sum of the sampled dc uncertainty and the hold mode noise. A plot of the total output noise vs. the equivalent input bandwidth of the converter being used is given in Figure 4.


Figure 4. RMS Noise vs. Input Bandwidth of ADC

## DRIVING THE ANALOG INPUTS

For best performance, it is important to drive the AD783 analog input from a low impedance signal source. This enhances the sampling accuracy by minimizing the analog and digital crosstalk. Signals which come from higher impedance sources (e.g., over $5 \mathrm{k} \Omega$ ) will have a relatively higher level of crosstalk. For applications where signals have high source impedance, an operational amplifier buffer in front of the AD783 is required. The AD711 (precision BiFET op amp) is recommended for these applications.

## HIGH FREQUENCY SAMPLING

Aperture jitter and distortion are the primary factors which limit frequency domain performance of a sample-and-hold amplifier. Aperture jitter modulates the phase of the hold command and produces an effective noise on the sampled analog input. The magnitude of the jitter induced noise is directly related to the frequency of the input signal.

A graph showing the magnitude of the jitter induced error vs. frequency of the input signal is given in Figure 5.
The accuracy in sampling high frequency signals is also constrained by the distortion and noise created by the sample-andhold. The level of distortion increases with frequency and reduces the "effective number of bits" of the conversion.
Measurements of Figures 6 and 7 were made using a 14-bit $\mathrm{A} / \mathrm{D}$ converter with $\mathrm{V}_{\mathrm{IN}}=5 \mathrm{~V} \mathrm{p}-\mathrm{p}$ and a sample frequency of 100 ksps .


Figure 5. Error Magnitude vs. Frequency


Figure 6. Total Harmonic Distortion vs. Frequency


Figure 7. Signal/(Noise and Distortion) vs. Frequency

## AD783 TO AD670 INTERFACE

The 15 MHz small signal bandwidth of the AD783 makes it a good choice for undersampling applications. Figure 8 shows the interface between the AD783 and the AD670 ADC, where the AD783 samples the incoming IF signal. For this particular application, the IF carrier was 10.7 MHz and the information signal was a 5 kHz FSK-modulated tone. The sample-and-hold signal is applied to the 8 -bit AD670 ADC and then digitally processed for analysis.
The CLKIN signal is connected directly to the S/H pin of the AD783 and must comply with the acquisition and settling requirements of the SHA. A delayed version of CLKIN is applied to the $\mathrm{R} / \mathrm{W}$ input of the AD670 in order to accommodate the hold-mode settling requirements of the AD783. The $10 \mu \mathrm{~s}$ conversion speed of the AD670 combined with the 150 ns hold-mode settling time of the AD783 result in a total system throughput of $10.15 \mu \mathrm{~s}$.
By keeping the 10.7 MHz IF input to the AD783 at a low amplitude, 255 mV p-p, the resultant distortion and jitterinduced noise result in approximately 45 dB of dynamic range. The AD670 can be conveniently configured such that its fullscale input range is 255 mV in order to retain the full 8 -bit dynamic range of the converter. The maximum sample rate of the AD670 is $10 \mu \mathrm{~s}$; therefore, to comply with the Nyquist criteria the maximum information bandwidth is 50 kHz .


Figure 8. AD783 to AD670 Interface

## AD783 to AD671 (12-Bit, 500 ns ADC) Interface

The AD783 to AD671 interface requires an op amp, a dual flipflop, and a monostable multivibrator or "one-shot." The op amp amplifies the $\pm 2.5 \mathrm{~V}$ output of the AD783 to the full-scale input of the AD671. Appropriate op amps include the AD841 and AD845 (see the AD671 data sheet for additional information). The flip-flops and one-shot are used to generate the AD671 ENCODE pulse and the appropriately timed AD783 S/H pulse.

A master sampling clock is tied to the clock input of flip-flopl and the input of the one-shot. The D1 input of flip-flopl should be tied high and the one-shot should be configured to generate a pulse on a rising edge of the sampling clock. The rising edge of the sampling clock causes the $\overline{\mathrm{Q} 1}$ output of the flip-flop to go low placing the AD783 into hold mode. Simultaneously, a low going pulse is generated at the one-shot output. The length of this pulse would usually be made long enough to allow the output of the AD783 to settle (hold-mode settling time), but because of the error-correcting ability of the AD671, the length of this pulse may be reduced to approximately 200 ns .
The low-going one-shot output is connected to the clock input of flip-flop2. The D2 input of flip-flop2 is tied high. The rising edge of the low-going pulse toggles the Q2 output of flip-flop2 to a high state. This output, which is tied to the ENCODE input of the AD671, initiates a conversion of the buffered output signal of the AD783. The AD671 issues the signal DAV when the conversion is complete. The DAV signal is tied to the asynchronous $\overline{\text { CLR1 }}$ and $\overline{\text { CLR2 }}$ inputs of both flip-flops. When DAV goes low, the $\overline{\mathrm{Q} 1}$ output goes high returning the AD783 to the sample or acquisition mode. The Q2 output (ENCODE) returns low until it is again triggered by the rising edge of the one-shot output.

Figure 9. AD783 to AD671 Interface


## FEATURES

Excellent Hold Mode Distortion into $250 \Omega$ -88 dB @ 30 MSPS (2.3 MHz $\mathrm{V}_{\text {IN }}$ ) -83 dB @ 30 MSPS (12.1 MHz ViN ) - $74 \mathrm{~dB} @ 30 \mathrm{MSPS}$ (19.7 MHz V $\mathrm{IN}_{\text {IN }}$ )

16 ns Acquisition Time to $0.01 \%$
$<1$ ps Aperture Jitter
250 MHz Tracking Bandwidth
83 dB Feedthrough Rejection @ 20 MHz
$3.3 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ Spectral Noise Density
MIL-STD-Compliant Versions Available

## APPLICATIONS

A/D Conversion
Direct IF Sampling
Imaging/FLIR Systems
Peak Detectors
Radar/EW/ECM
Spectrum Analysis
CCD ATE

## GENERAL DESCRIPTION

The AD9100 is a monolithic track-and-hold amplifier which sets a new standard for high speed and high dynamic range applications. It is fabricated in a mature high speed complementary bipolar process. In addition to innovative design topologies, a custom package is utilized to minimize parasitics and optimize dynamic performance.
Acquisition time (hold to track) is 13 ns to $0.1 \%$ accuracy, and 16 ns to $0.01 \%$. The AD9100 boasts superlative hold-mode frequency domain performance; when sampling at 30 MSPS hold mode distortion is less than -83 dBfs for analog frequencies up to 12 MHz ; and -74 dBfs at 20 MHz . The AD9100 can also drive capacitive loads up to 100 pF with little degradation in acquisition time; it is therefore well suited to drive 8 - and 10 -bit flash converters at clock speeds to 50 MSPS. With a spectral noise density of $3.3 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ and feedthrough rejection of 83 dB at 20 MHz , the AD9100 is well suited to enhance the dynamic range of many 8 - to 16 -bit systems.

BLOCK DIAGRAM


The AD9100 is "user friendly" and easy to apply: (1) it requires $+5 \mathrm{~V} /-5.2 \mathrm{~V}$ power supplies; (2) the hold capacitor and switch power supply decoupling capacitors are built into the DIP package; (3) the encode clock is differential ECL to minimize clock jitter; (4) the input resistance is typically $800 \mathrm{k} \Omega$; (5) the analog input is internally clamped to prevent damage from voltage transients.
The AD9100 is available in a 20-lead side-brazed "skinny DIP" package and a 28 -lead LCC package. Commercial, industrial, and military temperature grade parts are available. Consult the factory for information about the availability of 883 -qualified devices.

## PRODUCT HIGHLIGHTS

1. Hold Mode Distortion is guaranteed.
2. Monolithic construction.
3. Analog input is internally clamped to protect against overvoltage transients and ensure fast recovery.
4. Output is short circuit protected.
5. Drives capacitive loads to 100 pF .
6. Differential ECL clock inputs.

## PIN DESIGNATIONS



## *Patent pending.

This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.


## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

Supply Voltages ( $\pm \mathrm{V}_{\mathrm{s}}$ ) . . . . . . . . . . . . . . . . . . . . . . $\pm 6 \mathrm{~V}$ Continuous Output Current . . . . . . . . . . . . . . . . . . . 70 mA Analog Input Voltage ${ }^{2}$. . . . . . . . . . . . . . . . . . . . . . . . $\pm 5 \mathrm{~V}$ Operating Temperature Range (Case)
AD9100JD. ELECTRICAL CHARACTERISTICS $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

AD9100AD/AE . . . . . . . . . . . . . . . . . . . $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
AD9100SD/SE . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Junction Temperature . . . . . . . . . . . . . . . . . . . . . $+175^{\circ} \mathrm{C}$
Storage Temperature . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Soldering Temperature ( 10 sec ) . . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
(unless otherwise noted, $+\mathrm{V}_{\mathrm{S}}=+5 \mathrm{~V} ;-\mathrm{V}_{\mathrm{S}}=-5.2 \mathrm{~V} ; \mathrm{R}_{\text {LOAD }}=100 \Omega ; \mathrm{R}_{\mathrm{IN}}=50 \Omega$ )

\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline Parameter \& Conditions \& Temp \& \begin{tabular}{l}
Test \\
Level
\end{tabular} \& \[
\begin{array}{|c|}
\hline \text { AD9 } \\
\text { Min }
\end{array}
\] \& \[
\begin{gathered}
\text { AE/SE/J] } \\
\text { Typ }
\end{gathered}
\] \& \[
\begin{aligned}
\& \mathrm{AD}_{\text {Max }}{ }^{3} \\
\&
\end{aligned}
\] \& Units \\
\hline \begin{tabular}{l}
DC ACCURACY \\
Gain \\
Offset \\
Output Resistance \\
Output Drive Capability PSRR \\
Pedestal Sensitivity to Supply
\end{tabular} \& \[
\begin{aligned}
\& \Delta \mathrm{V}_{\mathrm{IN}}=2 \mathrm{~V} \\
\& \mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V} \\
\& \\
\& \Delta \mathrm{~V}_{\mathrm{S}}=0.5 \mathrm{~V} \mathrm{p}-\mathrm{p} \\
\& \Delta \mathrm{~V}_{\mathrm{S}}=0.5 \mathrm{~V} p-\mathrm{p}
\end{aligned}
\] \& \begin{tabular}{l}
Full \\
Full \\
\(25^{\circ} \mathrm{C}\) \\
Full \\
Full \\
Full
\end{tabular} \& \[
\begin{aligned}
\& \text { VI } \\
\& \text { VI } \\
\& \text { V } \\
\& \text { VI } \\
\& \text { VI } \\
\& \text { VI }
\end{aligned}
\] \& \[
\begin{aligned}
\& 0.989 \\
\& -5 \\
\& \\
\& \pm 40 \\
\& 48
\end{aligned}
\] \& \[
\begin{aligned}
\& 0.994 \\
\& \pm 1 \\
\& 0.4 \\
\& \pm 60 \\
\& 55 \\
\& 0.9
\end{aligned}
\] \& +5

3 \& | V/V mV |
| :--- |
| $\Omega$ |
| mA |
| dB |
| $\mathrm{mV} / \mathrm{V}$ | <br>

\hline ANALOG INPUT/OUTPUT Output Voltage Range Input Bias Current Input Overdrive Current ${ }^{4}$ Input Capacitance Input Resistance \& $\mathrm{V}_{\text {IN }}= \pm 4 \mathrm{~V} ; \mathrm{R}_{\text {IN }}=50 \Omega$ \& | Full |
| :--- |
| $25^{\circ} \mathrm{C}$ |
| Full |
| $25^{\circ} \mathrm{C}$ |
| $25^{\circ} \mathrm{C}$ |
| $25^{\circ} \mathrm{C}, \mathrm{T}_{\text {max }}$ |
| $\mathrm{T}_{\text {MIN }}$ | \& \[

$$
\begin{aligned}
& \text { VI } \\
& \text { VI } \\
& \text { VI } \\
& \text { V } \\
& \text { V } \\
& \text { VI } \\
& \text { VI }
\end{aligned}
$$

\] \& \[

$$
\begin{aligned}
& +2 \\
& -8 \\
& -16 \\
& \\
& 350 \\
& 200
\end{aligned}
$$

\] \& \[

$$
\begin{aligned}
& \pm 2.2 \\
& \pm 3 \\
& \pm 22 \\
& 1.2 \\
& 800
\end{aligned}
$$

\] \& \[

$$
\begin{aligned}
& -2 \\
& +8 \\
& +16
\end{aligned}
$$

\] \& | V |
| :--- |
| $\mu \mathrm{A}$ |
| $\mu \mathrm{A}$ |
| mA |
| pF |
| $\mathrm{k} \Omega$ |
| $\mathrm{k} \Omega$ | <br>


\hline | CLOCK/CLOCK INPUTS |
| :--- |
| Input Bias Current |
| Input Low Voltage ( $\mathrm{V}_{\mathrm{IL}}$ ) |
| Input High Voltage ( $\mathrm{V}_{\mathrm{IH}}$ ) | \& $\mathrm{CL} / \overline{\mathrm{CL}}=-1.0 \mathrm{~V}$ \& | Full |
| :--- |
| Full |
| Full | \& \[

$$
\begin{aligned}
& \text { VI } \\
& \text { VI } \\
& \text { V }
\end{aligned}
$$

\] \& \[

$$
\begin{aligned}
& -1.8 \\
& -1.0
\end{aligned}
$$

\] \& 4 \& \[

$$
\begin{aligned}
& 5 \\
& -1.5 \\
& -0.8
\end{aligned}
$$

\] \& \[

$$
\begin{array}{|l}
\mathrm{mA} \\
\mathrm{~V} \\
\mathrm{~V}
\end{array}
$$
\] <br>

\hline | TRACK MODE DYNAMICS |
| :--- |
| Bandwidth ( -3 dB ) |
| Slew Rate |
| Overdrive Recovery Time ${ }^{4}$ (to $0.1 \%$ ) 2nd Harm. Dist. ( $20 \mathrm{MHz}, 2 \mathrm{~V}$ p-p) 3rd Harm. Dist. ( $20 \mathrm{MHz}, 2 \mathrm{~V}$ p-p) Integrated Output Noise ( $1-200 \mathrm{MHz}$ ) RMS Spectral Noise @ 10 MHz | \& \[

$$
\begin{aligned}
& \mathrm{V}_{\text {OUT }} \leq 0.4 \mathrm{~V} \text { p-p } \\
& 4 \mathrm{~V} \text { Step } \\
& 4 \mathrm{~V} \text { Step } \\
& \mathrm{V}_{\mathrm{IN}}= \pm 4 \mathrm{~V} \text { to } 0 \mathrm{~V}
\end{aligned}
$$

\] \& | Full $25^{\circ} \mathrm{C}$ |
| :--- |
| Full |
| $25^{\circ} \mathrm{C}$ |
| Full |
| Full |
| $25^{\circ} \mathrm{C}$ |
| $25^{\circ} \mathrm{C}$ | \& \[

$$
\begin{aligned}
& \mathrm{IV} \\
& \mathrm{IV} \\
& \mathrm{IV} \\
& \mathrm{~V} \\
& \mathrm{~V} \\
& \mathrm{~V} \\
& \mathrm{~V} \\
& \mathrm{~V}
\end{aligned}
$$

\] \& \[

$$
\begin{aligned}
& 150 \\
& 550 \\
& 500
\end{aligned}
$$

\] \& \[

$$
\begin{aligned}
& 250 \\
& 850 \\
& \\
& 21 \\
& -65 \\
& -75 \\
& 45 \\
& 3.3
\end{aligned}
$$

\] \& \& | MHz |
| :--- |
| V/us |
| V/us |
| ns |
| dBc |
| dBc |
| $\mu \mathrm{V}$ |
| $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ | <br>


\hline | HOLD MODE DYNAMICS |
| :--- |
| Worst Harmonic ( $2.3 \mathrm{MHz}, 30 \mathrm{MSPS}$ ) |
| Worst Harmonic ( $12.1 \mathrm{MHz}, 30 \mathrm{MSPS}$ ) |
| Worst Harmonic ( $12.1 \mathrm{MHz}, 30 \mathrm{MSPS}$ ) |
| Worst Harmonic (12.1 MHz, 30 MSPS ) |
| Worst Harmonic (19.7 MHz, 30 MSPS) |
| Hold Noise ${ }^{5}$ |
| Droop Rate ${ }^{6}$ |
| Feedthrough Rejection ( 20 MHz ) | \& \[

$$
\begin{aligned}
& \mathrm{V}_{\text {OUT }}=2 \mathrm{Vp}-\mathrm{p} \\
& \mathrm{~V}_{\text {OUT }}=2 \mathrm{Vpp-p} \\
& \mathrm{~V}_{\text {OUT }}=2 \mathrm{Vp}-\mathrm{p} \\
& \mathrm{~V}_{\text {OUT }}=2 \mathrm{Vpp}-\mathrm{p} \\
& \mathrm{~V}_{\text {OUT }}=2 \mathrm{Vp}-\mathrm{p} \\
& \mathrm{~V}_{\text {IN }}=0 \mathrm{~V} \\
& \mathrm{~V}_{\text {IN }}=2 \mathrm{Vp}-\mathrm{p}
\end{aligned}
$$

\] \& \[

$$
\begin{aligned}
& 25^{\circ} \mathrm{C} \\
& 25^{\circ} \mathrm{C} \\
& \mathrm{~T}_{\text {MAX }} \\
& \mathrm{T}_{\text {MIN }} \\
& 25^{\circ} \mathrm{C} \\
& 25^{\circ} \mathrm{C} \\
& 25^{\circ} \mathrm{C} \\
& \mathrm{~T}_{\text {MIN }} \\
& \mathrm{T}_{\text {MAX }} \\
& \text { Full }
\end{aligned}
$$

\] \& \[

$$
\begin{array}{|l}
\mathrm{V} \\
\mathrm{IV} \\
\mathrm{IV} \\
\mathrm{IV} \\
\mathrm{~V} \\
\mathrm{~V} \\
\mathrm{VI} \\
\mathrm{VI} \\
\mathrm{VI} \\
\mathrm{~V}
\end{array}
$$

\] \& \& \[

$$
\begin{aligned}
& -83 \\
& -80 \\
& \\
& -77 \\
& -74 \\
& 300 \times \mathrm{t}_{\mathrm{H}} \\
& 1 \\
& 7 \\
& 5 \\
& 83
\end{aligned}
$$

\] \& | $\begin{aligned} & -72 \\ & -70 \\ & -68 \end{aligned}$ |
| :--- |
| 6 |
| 40 |
| 30 | \& | dBfs |
| :--- |
| dBfs |
| dBfs |
| dBfs |
| dBfs |
| V/s rms $\pm \mathrm{mV} / \mu \mathrm{s}$ $\pm \mathrm{mV} / \mu \mathrm{s}$ $\pm \mathrm{mV} / \mu \mathrm{s}$ |
| dB | <br>


\hline | TRACK-TO-HOLD SWITCHING |
| :--- |
| Aperture Delay |
| Aperture Jitter |
| Pedestal Offset |
| Transient Amplitude |
| Settling Time to 1 mV |
| Glitch Product | \& \[

$$
\begin{aligned}
& \mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V} \\
& \mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V} \\
& \mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V}
\end{aligned}
$$
\] \& $25^{\circ} \mathrm{C}$

$25^{\circ} \mathrm{C}$
$25^{\circ} \mathrm{C}$
Full
Full
Full

$25^{\circ} \mathrm{C}$ \& \[
$$
\begin{array}{|l}
\mathrm{V} \\
\mathrm{~V} \\
\mathrm{VI} \\
\mathrm{VI} \\
\mathrm{~V} \\
\mathrm{IV} \\
\mathrm{~V} \\
\hline
\end{array}
$$

\] \& \[

$$
\begin{aligned}
& -5 \\
& -10
\end{aligned}
$$

\] \& \[

$$
\begin{aligned}
& +800 \\
& <1 \\
& \pm 1 \\
& \pm 6 \\
& 7 \\
& 15 \\
& \hline
\end{aligned}
$$

\] \& \[

$$
\begin{aligned}
& +5 \\
& +10 \\
& 10
\end{aligned}
$$
\] \& ps ps mV mV mV ns pV -s <br>

\hline
\end{tabular}

| Parameter | Conditions | Temp | Test <br> Level | AD9100AE/SE/JD/AD/SD ${ }^{3}$ |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max |  |
| HOLD-TO-TRACK SWITCHING |  |  |  |  |  |  |  |
| Acquisition Time to 0.1\% | 2 V Step | $25^{\circ} \mathrm{C}$ | V |  | 13 |  | ns |
| Acquisition Time to 0.01\% | 2 V Step | Full | IV |  | 16 | 23 | ns |
| Acquisition Time to $0.01 \%$ | 4 V Step | $25^{\circ} \mathrm{C}$ | V |  | 20 |  | ns |
| POWER SUPPLY |  |  |  |  |  |  |  |
| Power Dissipation | * | Full | VI |  | 1.05 | 1.25 | W |
| + $\mathrm{V}_{\text {S }}$ Current |  | Full | VI |  | 96 | 118 | mA |
| - $\mathrm{V}_{\mathrm{S}}$ Current |  | Full | VI |  | 116 | 132 | mA |

## NOTES

${ }^{1}$ Absolute maximum ratings are limiting values to be applied individually, and beyond which the serviceability of the circuit may be impaired. Functional operability is not necessarily implied. Exposure to absolute maximum rating conditions for an extended period of time may affect device reliability.
${ }^{2}$ Analog input voltage should not exceed $\pm \mathrm{V}_{\mathrm{s}}$.
${ }^{3} \mathrm{AD} 9100 \mathrm{JD}: 0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$. AD9100AD: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. AD9100SD: $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. DIP $\theta_{\mathrm{JA}}=38^{\circ} \mathrm{C} / \mathrm{W}$; this is valid with the device mounted flush to a grounded 2 oz copper clad board with 16 sq inches of surface area and no air flow. LCC $\theta_{\mathrm{JA}}=48^{\circ} \mathrm{C} / \mathrm{W}$.
${ }^{4}$ The input to the AD9100 is internally clamped at $\pm 2.3 \mathrm{~V}$. The internal input series resistance is nominally $50 \Omega$.
${ }^{5}$ Hold mode noise is proportional to the length of time a signal is held. For example, if the hold time ( $\mathrm{t}_{\mathrm{H}}$ ) is 20 ns , the accumulated noise is typically $6 \mu \mathrm{~V}$ ( $300 \mathrm{~V} / \mathrm{s} \times 20 \mathrm{~ns}$ ). This value must be combined with the track mode noise to obtain total noise.
${ }^{6} \mathrm{Min}$ and max droop rates are based on the military temperature range $\left(-55^{\circ} \mathrm{C}\right.$ to $\left.+125^{\circ} \mathrm{C}\right)$. Refer to the "Droop Rate vs Temperature" chart for min/max limits over the commercial and industrial ranges.

Specifications subject to change without notice.

## EXPLANATION OF TEST LEVELS

## Test Level

I - $100 \%$ production tested.
II - $100 \%$ production tested at $+25^{\circ} \mathrm{C}$, and sample tested at specified temperatures.
III - Periodically sample tested.
IV - Parameter is guaranteed by design and characterization testing.
V - Parameter is a typical value only.
VI - All devices are $100 \%$ production tested at $+25^{\circ} \mathrm{C} .100 \%$ production tested at temperature extremes for extended temperature devices; sample tested at temperature extremes for commercial/industrial devices.

## DIP PIN DESCRIPTIONS/CONNECTIONS

| Pin No. | Description | Connection |
| :---: | :---: | :---: |
| 1 | - $\mathrm{V}_{\text {S }}$ | -5.2 V Power Supply |
| 2 | GND | Common Ground Plane |
| 3 | GND | Common Ground Plane |
| 4 | $\mathrm{V}_{\text {IN }}$ | Analog Input Signal |
| 5 | $-\mathrm{V}_{\text {S }}$ | -5.2 V Power Supply |
| 6 | BYPASS | $0.1 \mu \mathrm{~F}$ to Ground |
| 7 | - $\mathrm{V}_{\text {S }}$ | -5.2 V Power Supply |
| 8 | GND | Common Ground Plane |
| 9 | $\mathrm{V}_{\text {Out }}$ | Track-and-Hold Output |
| 10 | GND | Common Ground Plane |
| 11 | GND | Common Ground Plane |
| 12 | GND | Common Ground Plane |
| 13 | GND | Common Ground Plane |
| 14 | $+\mathrm{V}_{\text {S }}$ | +5 V, Power Supply |
| 15 | BYPASS | $0.1 \mu \mathrm{~F}$ to Ground |
| 16 | $+\mathrm{V}_{\text {S }}$ | +5 V , Power Supply |
| 17 | GND | Common Ground Plane |
| 18 | CLK | Complement ECL Clock |
| 19 | CLK | "True" ECL Clock |
| 20 | $+V_{s}$ | +5V Power Supply |

ORDERING GUIDE

| Model $^{\mathbf{1}}$ | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD9100JD | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Ceramic DIP | D-28 |
| AD9100AD | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Ceramic DIP | D-28 |
| AD9100AE | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Ceramic LCC | E-28A |
| AD9100SD | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Ceramic DIP | D-28 |
| AD9100SE | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Ceramic LCC | E-28A |

## NOTES

${ }^{1}$ Consult factory about availability of parts screened to MIL-STD-883.
${ }^{2}$ For outline information see Package Information section.

## LCC PIN DESCRIPTIONS/CONNECTIONS

| Pin No. | Description | Connection |
| :---: | :---: | :---: |
| 1 | GND | Common Ground Plane |
| 2 | GND | Common Ground Plane |
| 3 | NC | None |
| 4 | $-\mathrm{V}_{\text {S }}$ | -5.2 V Power Supply |
| 5 | $-\mathrm{V}_{\text {S }}$ | -5.2 V Power Supply |
| 6 | NC | None |
| 7 | $\mathrm{V}_{\text {IN }}$ | Analog Input Signal |
| 8 | $-\mathrm{V}_{\text {S }}$ | -5.2 V Power Supply |
| 9 | $-\mathrm{V}_{\mathrm{s}}$ | -5.2 V Power Supply |
| 10 | NC | None |
| 11 | $-V_{s}$ | -5.2 V Power Supply |
| 12 | $-V_{s}$ | -5.2 V Power Supply |
| 13 | $-\mathrm{V}_{\text {S }}$ | -5.2 V Power Supply |
| 14 | BYPASS | $0.1 \mu \mathrm{~F}$ to Pin 16 |
| 15 | V ${ }_{\text {Out }}$ | Track-and-Hold Output |
| 16 | BYPASS | $0.1 \mu \mathrm{~F}$ to Pin 14 |
| 17 | + $\mathrm{V}_{\text {S }}$ | +5 V Power Supply |
| 18 | $+\mathrm{V}_{\text {S }}$ | +5 V Power Supply |
| 19 | $+\mathrm{V}_{\text {S }}$ | +5V Power Supply |
| 20 | HOLDCAP | External Hold Capacitor |
| 21 | HOLDCAP | External Hold Capacitor |
| 22 | $+\mathrm{V}_{\text {s }}$ | +5V Power Supply |
| 23 | $+V_{\text {s }}$ | +5V Power Supply |
| 24 | GND | Common Ground Plane |
| 25 | $+\mathrm{V}_{\text {s }}$ | +5V Power Supply |
| 26 | $+V_{\text {S }}$ | +5V Power Supply |
| 27 | CLOCK | Complement ECL Clock |
| 28 | CLOCK | "True" ECL Clock |

FEATURES
350 MHz Sampling Bandwidth
125 MHz Sampling Rate
Excellent Hold Mode Distortion
-75dB@50 MSPS (25 MHz ViN)
$-57 \mathrm{~dB} @ 125 \mathrm{MSPS}\left(50 \mathrm{MHz} \mathrm{V}_{\mathrm{IN}}\right.$ )
7 ns Acquisition Time to 0.1\%
$<1$ ps Aperture Jitter
66 dB Feedthrough Rejection @ 50 MHz
$3.3 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ Spectral Noise Density
APPLICATIONS
Direct IF Sampling
Digital Sampling Oscilloscopes
HDTV Cameras
Peak Detectors
Radar/EW/ECM

## Spectrum Analysis

Test Equipment/CCD Testers
DDS DAC Deglitcher

## GENERAL DESCRIPTION

The AD9101 is an extremely accurate, general purpose, high speed sampling amplifier. Its fast and accurate acquisition speed allows for a wide range of frequency vs. resolution performance. The AD9101 is capable of 8 to 12 bits of accuracy at clock rates of 125 MSPS or 50 MSPS, respectively. This level of performance makes it an ideal driver for almost all 8- to 12-bit A/D encoders on the market today.
In effect, the AD9101 is a track-and-hold with a post amplifier. This configuration allows the front end sampler to operate at relatively low signal amplitudes. This results in dramatic improvement in both track and hold mode distortion while keeping power low.
The gain-of-four output amplifier has been optimized for fast and accurate large signal step settling characteristics even when heavily loaded. This amplifier's fast Settling Time Linearity (STL) characteristic causes the amplifier to be transparent to the low signal level distortion of the sampler. When sampled, output distortion levels reflect only the distortion performance of the sampler.
Dramatic SNR and distortion improvements can be realized when using the AD9101 with high speed flash converters. Flash converters generally have excellent linearity at dc and low frequencies. However, as signal slew rate increases, their performance degrades due to the internal comparators' aperture delay variations and finite gain bandwidth product.

## FUNCTIONAL BLOCK DIAGRAM



The benefits of using a track-and-hold ahead of a flash converter have been well known for many years. However, before the AD9101, there was no track-and-hold amplifier with sufficient bandwidth and linearity to markedly increase the dynamic performance of such flashes as the AD9002, AD9012, AD9020, and AD9060.
A new application made possible by the AD9101 is direct IF-to-digital conversion. Utilizing the Nyquist principle, the IF frequency can be rejected, and the baseband signal can be recovered. As an example, a 40 MHz IF is modulated by a 10 MHz bandwidth signal. By sampling at 25 MSPS, the signal of interest is detected.
The AD9101 is offered in commercial and military temperature ranges. Commercial versions include the AD9101AR in plastic SOIC and AD9101AE in ceramic LCC. Military devices are available in ceramic LCC. Contact the factory for availability of versions in DIP and/or military versions.

## PRODUCT HIGHLIGHTS

1. Guaranteed Hold-Mode Distortion
2. 125 MHz Sampling Rate to 8 Bits; 50 MHz to 12 Bits
3. 350 MHz Sampling Bandwidth
4. Super-Nyquist Sampling Capability
5. Output Offset Adjustable
[^85]
## AD9101-SPECIFICATIONS

ELECTRICAL CHARACTERISTICS (Unless otherwise noted, $+V_{S}=+5 V,-V_{S}=-5.2 \mathrm{~V}, \mathrm{R}_{\text {LOAD }}=100 \Omega$, $\mathrm{R}_{\mathrm{IN}}=50 \Omega$ )

|  |  | Test | AD9101 |  |  |  |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Parameter | Conditions | Temp | Level | Min | Typ | Max | Units

NOTES
${ }^{1}$ If the analog input exceeds $\pm 300 \mathrm{mV}$, the clock levels should be shifted as shown in the Theory of Operation section entitled "Driving the Encode Clock."
${ }^{2}$ Time to recover within rated error band from $160 \%$ overdrive.
${ }^{3}$ Sampling bandwidth is defined as the -3 dB frequency response of the input sampler to the hold capacitor when operating in the sampling mode. It is greater than tracking bandwidth because it does not include the bandwidth of the output amplifier.
${ }^{4} \mathrm{Hold}$ mode noise is proportional to the length of time a signal is held. For example, if the hold time $\left(\mathrm{t}_{\mathrm{H}}\right)$ is 20 ns , the accumulated noise is typically $3 \mu \mathrm{~V}$ ( $150 \mathrm{mV} / \mathrm{s} \times 20 \mathrm{~ns}$ ). This value must be combined with the track mode noise to obtain total noise.
${ }^{5}$ Total energy of worst case track-to-hold or hold-to-track glitch.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

Supply Voltage ( $+\mathrm{V}_{\mathrm{S}}$ ) . . . . . . . . . . . . . . . -0.5 V to +6 V
Supply Voltage ( $-\mathrm{V}_{\mathrm{S}}$ ) . . . . . . . . . . . . . . . . -6 V to +0.5 V
Analog Input Voltage . . . . . . . . . . . . . . . . . . . . . . . . $\pm 5$ V
CLOCK/CLOCK Input . . . . . . . . . . . . . . . -5 V to +0.5 V
Continuous Output Current ${ }^{4}$. . . . . . . . . . . . . . . . . . 70 mA
Storage Temperature . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Operating Temperature Range

| AE, AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| :---: | :---: |
| SE | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Junction Temperature (Ceramic) ${ }^{2}$ | $+175^{\circ} \mathrm{C}$ |
| Junction Temperature (Plastic) ${ }^{2}$ | $+150^{\circ} \mathrm{C}$ |
| Soldering Temperature (1 minute) ${ }^{3}$ | $+220^{\circ}$ |

## NOTES

${ }^{1}$ Absolute maximum ratings are limiting values to be applied individually, and beyond which the serviceability of the circuit may be impaired. Functional operability is not necessarily implied. Exposure to absolute maximum rating conditions for an extended period of time may affect device reliability.
${ }^{2}$ Typical thermal impedances (no air flow, soldered to PC board) are as follows: Ceramic LCC: $\theta_{\mathrm{JA}}=48^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=9.9^{\circ} \mathrm{C} / \mathrm{W}$; Plastic SOIC: $\theta_{\mathrm{JA}}=54^{\circ} \mathrm{C} / \mathrm{W}$; $\theta_{\mathrm{JC}}=7.3^{\circ} \mathrm{C} / \mathrm{W}$.
${ }^{3}$ For surface mount devices, mounted by vapor phase soldering. Prior to vapor phase soldering, plastic units should receive a minimum eight hour bakeout at $110^{\circ} \mathrm{C}$ to drive off any moisture absorbed in plastic during shipping or storage. Through-hole devices can be soldered at $+300^{\circ} \mathrm{C}$ for 10 seconds.
${ }^{4}$ Output is short circuit protected to ground. Continuous short circuit may affect device reliability.

## Pin Description

| Pin | Description | Connection |
| :---: | :---: | :---: |
| 1 | RTN | Gain Set Resistor Return* |
| 2 | RTN | Gain Set Resistor Return* |
| 3 | $\mathrm{C}_{\mathrm{B}+}$ | Bootstrap Capacitor (Positive Bias) |
| 4 | $+\mathrm{V}_{\mathrm{S}}$ | +5 V Power Supply (Analog) |
| 5 | $+\mathrm{V}_{\text {S }}$ | +5 V Power Supply (Analog) |
| 6 | GND | Hold Capacitor Ground |
| 7 | GND | Hold Capacitor Ground |
| 8 | $+\mathrm{V}_{\text {S }}$ | +5 V Power Supply (Digital) |
| 9 | $+\mathrm{V}_{\text {S }}$ | +5 V Power Supply (Digital) |
| 10 | CLK | True ECL T/H Clock |
| 11 | CLK | Complement ECL T/H Clock |
| 12 | $-\mathrm{V}_{\mathrm{s}}$ | -5.2 V Power Supply (Digital) |
| 13 | $-\mathrm{V}_{\text {S }}$ | -5.2 V Power Supply (Digital) |
| 14 | N/C | No Connection |
| 15 | $\mathrm{V}_{\text {IN }}$ | Analog Signal Input |
| 16 | GND | Ground (Signal Return) |
| 17 | $-\mathrm{V}_{\text {S }}$ | -5.2 V Power Supply (Analog) |
| 18 | $-\mathrm{V}_{\text {S }}$ | -5.2 V Power Supply (Analog) |
| 19 | $\mathrm{C}_{\text {B- }}$ | Bootstrap Capacitor (Negative Bias) |
| 20 | $\mathrm{V}_{\text {OUT }}$ | Analog Signal Output |

[^86]
## EXPLANATION OF TEST LEVELS

## Test Level

I - $100 \%$ production tested.
II - $100 \%$ production tested at $+25^{\circ} \mathrm{C}$, and sample tested at specified temperatures.
III - Periodically sample tested.
IV - Parameter is guaranteed by design and characterization testing.
V - Parameter is a typical value only.
VI - All devices are $100 \%$ production tested at $+25^{\circ} \mathrm{C}$. $100 \%$ production tested at temperature extremes for extended temperature devices; sample tested at temperature extremes for commercial/industrial devices.

ORDERING INFORMATION

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD9101AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Plastic SOIC | R-20 |
| AD9101AE | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | LCC | E-20A |
| AD9101SE | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | LCC | E-20A |

*For outline information see Package Information section.

## PIN CONFIGURATIONS

20-Pin SOIC


20-PIN LCC PACKAGE (E-20A)


CMOS Quad

## FEATURES

- Four Independent Sample-and-Holds
- Internal Hold Capacitors
- High Accuracy - 12-Bit
- Very Low Droop Rate ( $2 \mathrm{mV} / \mathrm{s}$ Typ)
- Output Buffers Stable for $C_{L} \leq 500 p F$
- TTLCMOS Compatible Logic Inputs
- Single or Dual Supply Applications
- Monolithic Low Power CMOS Design


## APPLICATIONS

- Signal Processing Systems
- Multichannel Data Acquisition Systems
- Automatic Test Equipment
- Medical and Analytical Instrumentation
- Event Analysis
- DAC Deglitching


## ORDERING INFORMATION ${ }^{\dagger}$

|  |  |  | PACKAGE |
| :---: | :---: | :---: | :---: |
|  | OPERATING |  |  |
|  | PLASTIC | CERDIP | TEMPERATURE |
|  | 16-PIN | 16-PIN | RANGE |
|  | - | SMP04AQ/883* | MIL |
|  | SMP04EP | SMP04EQ | XIND |
| SMP04ES ${ }^{\dagger \dagger}$ | - | XIND |  |

- Consult factory for $\mathbf{8 8 3}$ data sheet.
$\dagger$ Burn-in is available on extended industrial temperature range parts in CerDIP and plastic DIP packages.
tt For availability and burn-in information on SO packages, contact your local sales office.


## PIN CONNECTIONS

| $V_{\text {out2 }} 1$ | $1{ }^{16} V_{D D}$ |  |
| :---: | :---: | :---: |
| Vout 12 | 15 Vout 3 | 16-PIN CERDIP |
| VIN 13 | 14 Vout 4 | (Q-Suffix) |
| N.C. 4 | 13 V S | 16-PIN PLASTIC DIP |
| $\mathrm{V}_{\mathrm{iN} 2} 5$ | 12. $\mathrm{VIN}_{4}$ | (P-Suffix) |
| $5 / H_{1} 6$ | 11 Vin |  |
| S/H2 7 | 10] $\mathrm{S} / \mathrm{H}_{4}$ | 16-PIN SO |
| DGND | 9] $\mathrm{S} / \mathrm{H}_{3}$ | (S-Suffix) |

## GENERAL DESCRIPTION

The SMP-04 is a monolithic quad sample-and-hold; it has four internal precision buffer amplifiers and internal hold capacitors. It is manufactured in PMI's advanced oxide isolated CMOS technology to obtain high accuracy, low droop rate and fast acquisition time required by data acquisition and signal processing systems. The device can acquire an 8 -bit input signal to $\pm 1 / 2$ LSB in less than seven microseconds. The SMP-04 can operate from single or dual power supplies with TTL/CMOS logic compatibility. Its output swing includes the negative supply.
The SMP-04 is ideally suited for a wide variety of sample-andhold applications including amplifier offset or VCA gain adjustments. One or more can be used with a single or multiple DACs to provide multiple set points within a system.
The SMP-04 offers significant cost and size reduction over equivalent module or discrete designs. It is available in a 16-pin hermetic or plastic DIP and surface mount SOIC packages. It is specified over the extended industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. See SMP-04/883 data sheet for $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ specifications.

FUNCTIONAL DIAGRAM


ABSOLUTE MAXIMUM RATINGS $\left(T_{A}=+25^{\circ} \mathrm{C}\right.$ unless otherwise noted)

| $\mathrm{V}_{\mathrm{DD}}$ to DGND .................................................. -0.3V, 17 V |  |
| :---: | :---: |
|  |  |
| $V_{\text {Logic }}$ to DG |  |
| $V_{\text {IN }}$ to DGND |  |
| V |  |
| Analog Output Current $\qquad$ $\pm 20 \mathrm{~mA}$ (Not short-circuit protected) |  |
| Digital Input Voltage to DGND ................... $-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |  |
| Operating Temperature Range |  |
| EQ, EP, ES |  |
| AQ ....................................................... $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  |
| Junction Temperature ............................................. $+150^{\circ} \mathrm{C}$ |  |
| Storage Temperature ................................ $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |  |
| Lead Temperature (Soldering, 60 sec ) ..................... $+300^{\circ} \mathrm{C}$ |  |


| PACKAGE TYPE | $\Theta_{\text {IA }}($ Note 1$)$ | $\Theta_{\text {jc }}$ | UNITS |
| :--- | :---: | :---: | :---: |
| 16 -Pin CerDIP (Q) | 94 | 12 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 16-Pin Plastic DIP (P) | 76 | 33 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 16 -Pin SO (S) | 92 | 27 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTE:

1. $\Theta_{j A}$ is specified for worst case mounting conditions, i.e., $\Theta_{j A}$ is specified for device in socket for CerDIP and P-DIP packages; $\Theta_{i A}$ is specified for device soldered to printed circuit board for SO package.

## CAUTION:

1. Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and function operation at or above this specification is not implied. Exposure to the above maximum rating conditions for extended periods may affect device reliability.
2. Digital inputs and outputs are protected; however, permanent damage may occur on unprotected units from high-energy electrostatic fields. Keep units in conductive foam or packaging at ail times until ready to use. Use proper antistatic handling procedures.
3. Remove power before inserting or removing units from their sockets.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{DD}}=+12.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=\mathrm{DGND}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=$ No Load, $\mathrm{T}_{\mathrm{A}}=$ Operating Temperature Range specified in Absolute Maximum Ratings, unless otherwise specified.

| PARAMETER | SYMBOL | CONDITIONS | SMP-04 |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | UNITS |
| Linearity Error |  |  | - | 0.01 | - | \% |
| Buffer Offset Voltage | $\mathrm{V}_{\text {OS }}$ | $\mathrm{V}_{\text {IN }}=6 \mathrm{~V}$ | -10 | $\pm 2.5$ | +10 | mV |
| Hold Step | $\mathrm{V}_{\mathrm{HS}}$ | $\mathrm{V}_{\text {IN }}=6 \mathrm{~V}$ | - | 1 | $\pm 4$ | mV |
| Droop Rate | $\Delta \mathrm{V} / \Delta \mathrm{t}$ | $\mathrm{V}_{\mathrm{IN}}=6 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | - | 2 | 25 | $\mathrm{mV} / \mathrm{s}$ |
| Output Source Current | $I_{\text {Source }}$ | $\mathrm{V}_{\text {IN }}=6 \mathrm{~V}$ (Note 1) | 1.2 | - | - | mA |
| Output Sink Current | $\mathrm{I}_{\text {SINK }}$ | $\mathrm{V}_{1 \mathrm{~N}}=6 \mathrm{~V}$ (Note 1) | 0.5 | - | - | mA |
| Output Voltage Range | OVR | $\begin{aligned} & R_{L}=20 \mathrm{k} \Omega \\ & R_{L}=10 \mathrm{k} \Omega \end{aligned}$ | $\begin{aligned} & 0.06 \\ & 0.06 \end{aligned}$ | - | $\begin{array}{r} 10.0 \\ 9.5 \end{array}$ | V |
| LOGIC CHARACTERISTICS |  | : |  | . |  |  |
| Logic Input High Voltage | $\mathrm{V}_{\text {INH }}$ |  | 2.4 | - | - | V |
| Logic Input Low Voltage | $\mathrm{V}_{\text {INL }}$ |  | - | - | 0.8 | V |
| Logic Input Current | $\mathrm{I}_{\mathrm{IN}}$ |  | - | 0.5 | 1 | $\mu \mathrm{A}$ |
| DYNAMIC PERFORMANCE (Note 2) |  |  |  |  |  |  |
| Acquisition Time | $t_{A}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, 0$ to 10 V step to $0.1 \%$ | - | 7 | - | $\mu \mathrm{s}$ |
| Acquisition Time | $t_{A}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, 0$ to 10 V step to $0.01 \%$ | - | 9 | - | $\mu \mathrm{s}$ |
| Hold Mode Settling Time | $\mathrm{t}_{\mathrm{H}}$ | To 1 mV | - | 1 | - | $\mu \mathrm{s}$ |
| Slew Rate | SR | $\mathrm{R}_{\mathrm{L}}=20 \mathrm{k} \Omega$ (Note 3) | 3 | 4 | - | $\mathrm{V} / \mathrm{\mu s}$ |
| Capacitive Load Stability | $C_{L}$ | <30\% Overshoot | - | 500 | - | pF |
| Analog Crosstalk |  | 0 to 10 V step | - | -80 | - | dB |
| SUPPLY CHARACTERISTICS |  |  |  |  |  |  |
| Power Supply Rejection Ratio | PSRR | $10.8 \leq \mathrm{V}_{\mathrm{DD}} \leq 13.2 \mathrm{~V}$ | 60 | 75 | - | dB |
| Supply Current | $\mathrm{I}_{\text {D }}$ |  | - | 4 | 7 | mA |
| Power Dissipation | $\mathrm{P}_{\text {DIS }}$ |  | - | - | 84 | mW |

## NOTES:

1. Outputs are capable of sinking and sourcing over 20 mA but linearity and offset are guaranteed at specified load levels
2. All input control signals are specified with $\mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of $+5 \mathrm{~V})$ and timed from a voltage level of 1.6 V .
3. Slew rate is measured in the sample mode with a 0 to 10 volt step from 20 to 80\%.

## SMP04

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{DD}}=+5.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=-5.0 \mathrm{~V}, \mathrm{DGND}=0.0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=$ NoLoad, $\mathrm{T}_{\mathrm{A}}=$ Operating Temperature Range specified in Absolute Maximum Ratings, unless otherwise specified.

| PARAMETER | SYMBOL | CONDITIONS | MIN | $\begin{gathered} \text { SMP-04 } \\ \text { TYP } \end{gathered}$ | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Linearity Error |  |  | - | . 01 | - | \% |
| Buffer Offset Voltage | $v_{\text {os }}$ | $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ | -10 | $\pm 2.5$ | +10 | mV |
| Hold Step | $\mathrm{V}_{\mathrm{HS}}$ | $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ | - | -1 | $\pm 4$ | mV |
| Droop Rate | $\Delta \mathrm{V} / \Delta \mathrm{t}$ | $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | - | 2 | 25 | $\mathrm{mV} / \mathrm{s}$ |
| Output Resistance | $\mathrm{R}_{\text {out }}$ |  | - | 1 | - | $\Omega$. |
| Output Source Current | $\mathrm{I}_{\text {SOURCE }}$ | $\mathrm{V}_{\text {IN }}=\mathrm{OV}$ (Note 1) | 1.2 | - | - | mA |
| Output Sink Current | $\mathrm{I}_{\text {SINK }}$ | $\mathrm{V}_{\text {IN }}=\mathrm{OV}$ (Note 1) | 0.5 | - | - | mA |
| Output Voltage Range | OVR | $\mathrm{R}_{\mathrm{L}}=20 \mathrm{k} \Omega$ | -3.0 | - | +3.0 | V |
| LOGIC CHARACTERISTICS |  |  |  |  |  |  |
| Logic Input High Voltage | $\mathrm{V}_{\text {INH }}$ |  | 2.4 | - | - | V |
| Logic Input Low Voitage | $\mathrm{v}_{\text {INL }}$ |  | - | - | 0.8 | V |
| Logic Input Current | $\mathrm{I}_{\mathrm{N}}$ |  | - | 0.5 | 1 | $\mu \mathrm{A}$ |
| DYNAMIC PERFORMANCE (Note 2) |  |  |  |  |  |  |
| Acquisition Time | ${ }_{A}$ | -3 to +3 V step to $0.1 \%$ | - | 7 | - | $\mu \mathrm{s}$ |
| Acquisition Time | ${ }_{\text {t }}$ | -3 to +3 V step to $0.01 \%$ | - | 9 | - | $\mu \mathrm{s}$ |
| Hold Mode Setting Time | $\mathrm{t}_{\mathrm{H}}$ | To 1 mV | - | 1 | - | $\mu \mathrm{s}$ |
| Slew Rate | SR | $\mathrm{R}_{\mathrm{L}}=20 \mathrm{k} \Omega$ (Note 3) | - | 3 | - | $\mathrm{V} / \mathrm{\mu s}$ |
| Capacitive Load Stability | $C_{L}$ | <30\% Overshoot | 500 | - | - | pF |
| SUPPLY CHARACTERISTICS |  |  |  |  |  |  |
| Power Supply Rejection Ratio | PSRR | $\pm 5 \leq \mathrm{V}_{\text {DD }} \leq \pm 16 \mathrm{~V}$ | 60 | 75 | - | dB |
| Supply Current | $\mathrm{I}_{\mathrm{DD}}$ |  | - | 3.5 | 5.5 | mA |
| Power Dissipation | $\mathrm{P}_{\text {DIS }}$ |  | - | - | 55 | mW |

1. Outputs are capable of sinking and sourcing over 20 mA but linearity and offset are guaranteed at specified load levels.
2. All input control signals are specified with $\mathrm{t}_{\mathrm{r}}=\mathrm{I}_{\mathrm{f}}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of $+5 \mathrm{~V})$ and timed from a voltage level of 1.6 V .
3. Slew rate is measured in the sample mode with a -3 to +3 volt step from 20 to $80 \%$.

## FEATURES

- Internal Hold Capacitors
- Low Droop Rate
- TTLCMOS Compatible Logic Inputs
- Single or Dual Supply Operation
- Break-Before-Make Channel Addressing
- Compatible With CD4051 Pinout
- Low Cost


## APPLICATIONS

- Multiple Path Timing Deskew for A.T.E.
- Memory Programmers
- Mass Flow/Process Control Systems
- Multichannel Data Acquisition Systems
- Robotics and Control Systems
- Medical and Analytica! Instrumentation
- Event Analysis
- Stage Lighting Control

ORDERING INFORMATION ${ }^{\dagger}$

| PACKAGE: 16-PIN DIP/SO |  | OPERATING <br> CERDIP <br> 16-PIN |
| :---: | :---: | :---: |
| PLASTIC | TEMPERATURE |  |
| TBA* | 16-PIN | - |
| SMPORFQ | SMP08FP | MIL |
| - | SMP08FS | XIND |

- Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on industrial temperature range parts in CerDIP and plastic DIP packages.


## PIN CONNECTIONS



## GENERAL DESCRIPTION

The SMP-08 is a monolithic octal sample-and-hold; it has eight internal buffer amplifiers, input multiplexer, and internal hold capacitors. It is manufactured in an advanced oxide isolated CMOS technology to obtain high accuracy, low droop rate, and

Manufactured under the following U.S. patent: $4,739,281$
fast acquisition time. The SMP-08 has a typical linearity error of only $0.01 \%$ and can accurately acquire a 10-bit input signal to $\pm 1 / 2$ LSB in less than seven microseconds. The SMP-08's output swing includes the negative supply in both single and dual supply operation.
The SMP-08 was specifically designed for systems that use a calibration cycle to adjust a multiple of system parameters. The low cost and high level of integration makes the SMP-08 ideal for calibration requirements that have previously required an ASIC, or high cost multiple D/A converters.
The SMP-08 is also ideally suited for a wide variety of sample-and-hold applications including amplifier offset or VCA gain adjustments. One or more SMP-08s can be used with single or multiple DACs to provide multiple set points within a system.
The SMP-08 offers significant cost and size reduction over discrete designs. It is available in a 16-pin hermetic or plastic DIP, or surface mount SOIC package.

FUNCTIONAL DIAGRAM


[^87]ABSOLUTE MAXIMUM RATINGS (Note 1)

| $V_{\text {DD }}$ to DGND ...................................................-0.3V, 17 V |  |
| :---: | :---: |
| $V_{\text {DD }}$ to $V_{\text {SS }}$.......................................................-0.3V, 17V |  |
| V |  |
| $V_{\text {IN }}$ to DGND |  |
| $V_{\text {OUT }}$ to DGND |  |
| Analog Output Current .............................................. 20 |  |

(Not short-circuit protected)
Operating Temperature Range
FP, FS $\qquad$ $.40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Junction Temperature .................................................... $+150^{\circ} \mathrm{C}$
Storage Temperature .................................... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 60 sec )......................... $+300^{\circ} \mathrm{C}$

| PACKAGE TYPE | $\Theta_{\mu}$ (Note 2) | $\boldsymbol{\Theta}_{\boldsymbol{j c}}$ | UNITS |
| :--- | :---: | :---: | :---: |
| $16-$ Pin Hermetic DIP (Q) | 94 | 12 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $16-$ Pin Plastic DIP (P) | 76 | 33 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $16-$ Pin SO (S) | 92 | 27 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

NOTES:

1. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
2. $\Theta_{j \Lambda}$ is specified for worst case mounting conditions, i.e., $\Theta_{j \Lambda}$ is specified for device in socket for CerDIP and P-DIP packages; $\Theta_{\mathrm{iA}}$ is specitied for device soldered to printed circuit board for SO package.

## CAUTION:

1. Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation at or above this specification is not implied. Exposure to the above maximum rating conditions for extended periods may affect device reliability.
2. Digital inputs and outputs are protected; however, permanent damage may occur on unprotected units from high-energy electrostatic fields. Keep units in conductive foam or packaging at all times until ready to use. Use proper antistatic handling procedures.
3. Remove power before inserting or removing units from their sockets.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=-5 \mathrm{~V}, \mathrm{DGND}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=\mathrm{No}$ Load, $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ for SMP- 08 F , unless otherwise noted.


ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=-5 \mathrm{~V}, \mathrm{DGND}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=\mathrm{NoLoad}, \mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ for SMP-08F, unless otherwise noted. Continued

| PARAMETER | SYMBOL | CONDITIONS | MIN | $\begin{gathered} \text { SMP-08F } \\ \text { TYP } \end{gathered}$ | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SUPPLY CHARACTERISTICS |  |  |  |  |  |  |
| Power Supply Rejection Ratio | PSRR | $\mathrm{V}_{\mathrm{s}}= \pm 5 \mathrm{~V}$ to $\pm 6 \mathrm{~V}$ | 60 | 75 | - | dB |
| Supply Current | $\mathrm{I}_{\mathrm{D}}$ | $\begin{aligned} & \mathrm{T}_{A}=+25^{\circ} \mathrm{C} \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{A} \leq+85^{\circ} \mathrm{C} \end{aligned}$ | - | $\begin{aligned} & 5.5 \\ & 7.5 \end{aligned}$ | 7.5 9.5 | mA |

## NOTES:

1. Outputs are capable of sinking and sourcing over 20 mA but offset is guaran- 2. All input control signals are specified with $t_{r}=t_{4}=5 n s(10 \%$ to $90 \%$ of $+5 \mathrm{~V})$ and teed at specified load levels. timed from a voltage level of 1.6 V .

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{DD}}=+12 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{DGND}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=\mathrm{NoLoad}, \mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C} t 0+85^{\circ} \mathrm{C}$ for SMP-08F, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | SMP-08F |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX |  |
| Linearity Error |  | $60 \mathrm{mV} \leq \mathrm{V}_{\text {IN }} \leq 10 \mathrm{~V}$ | - | 0.01 | - | \% |
| Buffer Offset Voltage | $V_{\text {os }}$ | $\begin{aligned} & T_{A}=+25^{\circ} \mathrm{C} \\ & -40^{\circ} \mathrm{C} \leq T_{A} \leq+85^{\circ} \mathrm{C} \end{aligned}$ | - | $\begin{aligned} & 2.5 \\ & 3.5 \end{aligned}$ | 10 20 | mV |
| Hold Step | $V_{\text {HS }}$ | $\mathrm{V}_{1 \mathrm{~N}}=6 \mathrm{~V}$ | - | 1 | 4 | mV |
| Droop Rate | $\Delta \mathrm{VCH}^{\prime} / \Delta \mathrm{t}$ | $\mathrm{T}_{\text {A }}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\text {IN }}=6 \mathrm{~V}$ | - | 2 | 20 | $\mathrm{mV} / \mathrm{s}$ |
| Output Source Current | $I_{\text {SOURCE }}$ | $\mathrm{V}_{\text {IN }}=6 \mathrm{~V}$ (Note 1) | 1.2 | - | - | mA |
| Output Sink Current | $\mathrm{I}_{\text {SINK }}$ | $\mathrm{V}_{\text {IN }}=6 \mathrm{~V}$ (Note 1) | 0.5 | - | - | mA |
| Output Voltage Range |  | $\begin{aligned} & R_{L}=20 \mathrm{k} \Omega \\ & R_{L}=10 \mathrm{k} \Omega \end{aligned}$ | $\begin{aligned} & 0.06 \\ & 0.06 \end{aligned}$ | - | $\begin{array}{r} 10.0 \\ 9.5 \end{array}$ | V |
| LOGIC CHARACTERISTICS |  |  |  |  |  |  |
| Logic Input High Voltage | $V_{\text {INH }}$ |  | 2.4 | - | - | V |
| Logic Input Low voltage | $\mathrm{V}_{\text {INL }}$ |  | - | - | 0.8 | V |
| Logic input Current | $\mathrm{I}_{\mathrm{IN}}$ | $\mathrm{V}_{\text {IN }}=2.4 \mathrm{~V}$ | - | 0.5 | 1 | $\mu \mathrm{A}$ |
| DYNAMIC PERFORMANCE (Note 2) |  |  |  |  |  |  |
| Acquisition Time | $\mathrm{t}_{\mathrm{AO}}$ | $\mathrm{T}_{A}=+25^{\circ} \mathrm{C}, 0$ to 10 V to $0.1 \%$ | - | 9 | - | $\mu \mathrm{S}$ |
| Hold Mode Settling Time | $\mathrm{t}_{\mathrm{H}}$ | To $\pm 1 \mathrm{mV}$ of Final Value | - | 1 | - | $\mu \mathrm{s}$ |
| Channel Select Time | $\mathrm{t}_{\mathrm{CH}}$ |  | - | 90 | - | ns |
| Channel Deselect Time | ${ }_{\text {t }}$ |  | - | 45 | - | ns |
| Inhibit Recovery Time | $\mathrm{t}_{1 \mathrm{R}}$ |  | - | 90 | - | ns |
| Slew Rate | SR | $\mathrm{R}_{\mathrm{L}}=20 \mathrm{k} \Omega$ (Note 3) | 3 | 4 | - | $\mathrm{V} / \mathrm{\mu s}$ |
| Capacitive Load Stability |  | <30\% Overshoot | - | 500 | - | pF |
| Analog Crosstalk |  | 0 to 10 V Step | - | -72 | - | dB |
| SUPPLY CHARACTERISTICS |  |  |  |  |  |  |
| Power Supply Rejection Ratio | PSRR | $10.8 \mathrm{~V} \leq \mathrm{V}_{\mathrm{DD}} \leq 13.2 \mathrm{~V}$ | 60 | 75 | - | dB |
| Supply Current | $I_{\text {D }}$ | $\begin{aligned} & \mathrm{T}_{A}=+25^{\circ} \mathrm{C} \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{A} \leq+85^{\circ} \mathrm{C} \end{aligned}$ | - | 6.0 8.0 | 8.0 10.0 | mA |

## NOTES:

1. Outputs are capable of sinking and sourcing over 20 mA but offset is guaranteed at specified load levels.
2. All input control signals are specified with $t_{r}=t_{4}=5 n s(10 \%$ to $90 \%$ of $+5 \mathrm{~V})$ and timed from a voltage level of 1.6 V .
3. Slew rate is measured in the sample mode with a 0 to 10 V step from $20 \%$ to $80 \%$.

## FEATURES

High Speed Version of SMP-08 Internal Hold Capacitors Low Droop Rate TTL/CMOS Compatible Logic Inputs Single or Dual Supply Operation Break-Before-Make Channel Addressing Compatible With CD4051 Pinout Low Cost

## APPLICATIONS

Multiple Path Timing Deskew for A.T.E. Memory Programmers
Mass Flow/Process Control Systems Multichannel Data Acquisition Systems
Robotics and Control Systems
Medical and Analytical Instrumentation

## Event Analysis

## Stage Lighting Control

## GENERAL DESCRIPTION

The SMP-18 is a monolithic octal sample-and-hold; it has eight internal buffer amplifiers, input multiplexer, and internal hold capacitors. It is manufactured in an advanced oxide isolated CMOS technology to obtain high accuracy, low droop rate, and fast acquisition time. The SMP-18 has a typical linearity error of only $0.01 \%$ and can accurately acquire a 10 -bit input signal to $\pm 1 / 2$ LSB in less than 2.5 microseconds. The SMP-18's output swing includes the negative supply in both single and dual supply operation.
The SMP-18 was specifically designed for systems that use a calibration cycle to adjust a multiple of system parameters. The low cost and high level of integration make the SMP-18 ideal for calibration requirements that have previously required an ASIC, or high cost multiple D/A converters.
The SMP-18 is also ideally suited for a wide variety of sample-and-hold applications including amplifier offset or VCA gain adjustments. One or more SMP-18s can be used with single or multiple DACs to provide multiple set points within a system.

## FUNCTIONAL BLOCK DIAGRAM



The SMP-18 offers significant cost and size reduction over discrete designs. It is available in a 16 -pin hermetic, plastic DIP or narrow body SO-16 surface-mount SOIC package. The SMP-18 is a higher speed direct replacement for the SMP-08.

ELECTRICAL CHARACTERISTICS
$\left(@ V_{D D}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=-5 \mathrm{~V}, \mathrm{DGND}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=\right.$ No Load, $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ for SMP-18F, unless otherwise noted)

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Linearity Error <br> Buffer Offset Voltage <br> Hold Step <br> Droop Rate <br> Output Source Current <br> Output Sink Current <br> Output Voltage Range | $\mathrm{V}_{\mathrm{Os}}$ <br> $\mathrm{V}_{\mathrm{HS}}$ <br> $\Delta \mathrm{V}_{\mathrm{CH}} / \Delta \mathrm{t}$ <br> I SOURCE <br> $\mathrm{I}_{\text {SINK }}$ | $\begin{aligned} & -3 \mathrm{~V} \leq \mathrm{V}_{\mathrm{IN}} \leq+3 \mathrm{~V} \\ & \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V} \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}, \mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V} \\ & \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V}^{1} \\ & \mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V}^{1} \\ & \mathrm{R}_{\mathrm{L}}=20 \mathrm{k} \Omega \end{aligned}$ | $\begin{aligned} & 1.2 \\ & 0.5 \\ & -3.0 \end{aligned}$ | $\begin{aligned} & 0.01 \\ & 2.5 \\ & 3.5 \\ & 4 \\ & 2 \end{aligned}$ | 10 <br> 20 <br> 6 <br> 40 $+3.0$ | $\mathrm{\%}$ mV mV mV $\mathrm{mV} / \mathrm{s}$ mA mA V |
| LOGIC CHARACTERISTICS <br> Logic Input High Voltage Logic Input Low Voltage Logic Input Current | $\mathrm{V}_{\text {INH }}$ <br> $\mathrm{V}_{\text {INL }}$ <br> $\mathrm{I}_{\mathrm{IN}}$ | $\mathrm{V}_{\text {IN }}=2.4 \mathrm{~V}$ | 2.4 | 0.5 | $\begin{aligned} & 0.8 \\ & 1 \end{aligned}$ | V V <br> $\mu \mathrm{A}$ |
| DYNAMIC PERFORMANCE ${ }^{2}$ <br> Acquisition Time Hold Mode Settling Time Channel Select Time Channel Deselect Time Inhibit Recovery Time Slew Rate Capacitive Load Stability Analog Crosstalk | $\begin{aligned} & \mathrm{t}_{\mathrm{AQ}} \\ & \mathrm{t}_{\mathrm{H}} \\ & \mathrm{t}_{\mathrm{CH}} \\ & \mathrm{t}_{\mathrm{DCS}} \\ & \mathrm{t}_{\mathrm{IR}} \\ & \mathrm{SR} \end{aligned}$ | $\begin{aligned} & \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C},-3 \mathrm{~V} \text { to }+3 \mathrm{~V} \text { to } 0.1 \% \\ & \mathrm{To} \pm 1 \mathrm{mV} \text { of Final Value } \\ & <30 \% \text { Overshoot } \\ & -3 \mathrm{~V} \text { to }+3 \mathrm{~V} \text { Step } \end{aligned}$ |  | $\begin{aligned} & 3.5 \\ & 1 \\ & 90 \\ & 45 \\ & 90 \\ & 6 \\ & 500 \\ & -72 \end{aligned}$ |  | $\mu \mathrm{s}$ <br> $\mu \mathrm{s}$ <br> ns <br> ns <br> ns <br> $\mathrm{V} / \mu \mathrm{s}$ <br> pF <br> dB |
| SUPPLY CHARACTERISTICS <br> Power Supply Rejection Ratio Supply Current | $\begin{aligned} & \text { PSRR } \\ & \mathrm{I}_{\mathrm{DD}} \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{Ss}}= \pm 5 \mathrm{~V} \text { to } \pm 6 \mathrm{~V} \\ & \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \end{aligned}$ | 60 | $\begin{aligned} & 75 \\ & 5.5 \\ & 7.5 \end{aligned}$ | $\begin{aligned} & 7.5 \\ & 9.5 \end{aligned}$ | dB <br> mA <br> mA |

NOTES
${ }^{1}$ Outputs are capable of sinking and sourcing over 10 mA but offset is guaranteed at specified load levels.
${ }^{2}$ All input control signals are specified with $t_{r}=t_{f}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of $+5 \mathrm{~V})$ and timed from a voltage level of 1.6 V .
Specifications subject to change without notice.
ELECTRICAL CHARACTERISTICS $@ V_{D D}=+12 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{DGND}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=\mathrm{No}$ Load, $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ for

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Linearity Error |  | $60 \mathrm{mV} \leq \mathrm{V}_{\text {IN }} \leq 10 \mathrm{~V}$ |  | 0.01 |  | \% |
| Buffer Offset Voltage | $\mathrm{V}_{\text {OS }}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\text {IN }}=6 \mathrm{~V}$ |  | 2.5 | 10 | mV |
|  |  | $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}, \mathrm{V}_{\text {IN }}=6 \mathrm{~V}$ |  | 3.5 | 20 | mV |
| Hold Step | $\mathrm{V}_{\mathrm{HS}}$ | $\mathrm{V}_{\mathrm{IN}}=6 \mathrm{~V}$ |  | 4 | 6 | mV |
| Droop Rate | $\Delta \mathrm{V}_{\mathrm{CH}} / \Delta \mathrm{t}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\text {IN }}=6 \mathrm{~V}$ |  | 2 | 40 | $\mathrm{mV} / \mathrm{s}$ |
| Output Source Current | $\mathrm{I}_{\text {SOURCE }}$ | $\mathrm{V}_{\text {IN }}=6 \mathrm{~V}^{1}$ | 1.2 |  |  | mA |
| Output Sink Current | $\mathrm{I}_{\text {SINK }}$ | $\mathrm{V}_{\text {IN }}=6 \mathrm{~V}^{1}$ | 0.5 |  |  | mA |
| Output Voltage Range |  | $\mathrm{R}_{\mathrm{L}}=20 \mathrm{k} \Omega$ | 0.06 |  | 10.0 | V |
|  |  | $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ | 0.06 |  | 9.5 | V |
| LOGIC CHARACTERISTICS |  |  |  |  |  |  |
| Logic Input High Voltage | $\mathrm{V}_{\text {INH }}$ |  | 2.4 |  |  | V |
| Logic Input Low Voltage | $\mathrm{V}_{\text {INL }}$ |  |  |  | 0.8 | V |
| Logic Input Current | $\mathrm{I}_{\mathrm{IN}}$ | $\mathrm{V}_{\mathrm{IN}}=2.4 \mathrm{~V}$ |  | 0.5 | 1 | $\mu \mathrm{A}$ |
| DYNAMIC PERFORMANCE ${ }^{2}$ |  |  |  |  |  |  |
| Acquisition Time | $\mathrm{t}_{\mathrm{AQ}}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, 0$ to 10 V to $0.1 \%$ |  | 2.5 |  | $\mu \mathrm{s}$ |
| Hold Mode Settling Time | $\mathrm{t}_{\mathrm{H}}$ | To $\pm 1 \mathrm{mV}$ of Final Value |  | 1 |  | $\mu \mathrm{s}$ |
| Channel Select Time | $\mathrm{t}_{\mathrm{CH}}$ |  |  | 90 |  | ns |
| Channel Deselect Time | $\mathrm{t}_{\text {DCS }}$ |  |  | 45 |  | ns |
| Inhibit Recovery Time | $\mathrm{t}_{\text {IR }}$ |  |  | 90 |  | ns |
| Slew Rate ${ }^{3}$ | SR |  |  | 7 |  | V/us |
| Capacitive Load Stability |  | <30\% Overshoot |  | 500 |  | pF |
| Analog Crosstalk |  | 0 to 10 V Step |  | -72 |  | dB |


| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| SUPPLY CHARACTERISTICS |  |  |  |  |  |  |
| Power Supply Rejection Ratio | PSRR | $10.8 \mathrm{~V} \leq \mathrm{V}_{\mathrm{DD}} \leq 13.2 \mathrm{~V}$ | 60 | 75 |  | dB |
| Supply Current | $\mathrm{I}_{\mathrm{DD}}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |  | 6.0 | 8.0 | mA |
|  |  | $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ |  | 8.0 | 10.0 | mA |

NOTES
${ }^{1}$ Outputs are capable of sinking and sourcing over 10 mA but offset is guaranteed at specified load levels.
${ }^{2}$ All input control signals are specified with $\mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of $+5 \mathrm{~V})$ and timed from a voltage level of 1.6 V .
${ }^{3}$ Slew rate is measured in the sample mode with a 0 to 10 V step from $20 \%$ to $80 \%$.
Specifications subject to change without notice.

ABSOLUTE MAXIMUM RATINGS ${ }^{1}$
V $_{\text {DD }}$ to DGND . . . . . . . . . . . . . . . . . . . . . . -0.3 V, 17 V
$\mathrm{V}_{\mathrm{DD}}$ to $\mathrm{V}_{\text {ss }}$. . . . . . . . . . . . . . . . . . . . . . . . $-0.3 \mathrm{~V}, 17 \mathrm{~V}$
$\mathrm{V}_{\text {LOGIC }}$ to DGND . . . . . . . . . . . . . . . . . . . $-0.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}$
$\mathrm{V}_{\text {IN }}$ to DGND . . . . . . . . . . . . . . . . . . . . . . . . . $\mathrm{V}_{\text {SS }}$, $\mathrm{V}_{\text {DD }}$
V ${ }_{\text {OUT }}$ to DGND . . . . . . . . . . . . . . . . . . . . . . . . V V
Analog Output Current . . . . . . . . . . . . . . . . . . . . $\pm 20 \mathrm{~mA}$
(Not short-circuit protected)

## Operating Temperature Range

FQ, FP, FS . . . . . . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Junction Temperature . . . . . . . . . . . . . . . . . . . . . . $+150^{\circ} \mathrm{C}$
Storage Temperature . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 60 sec) . . . . . . . . . . . $+300^{\circ} \mathrm{C}$

| Package Type | $\boldsymbol{\theta}_{\mathbf{J A}}{ }^{2}$ | $\boldsymbol{\theta}_{\mathbf{J C}}$ | Units |
| :--- | :--- | :--- | :--- |
| 16-Pin Hermetic DIP (Q) | 94 | 12 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 16-Pin Plastic DIP (P) | 76 | 33 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 16-Pin SOIC (S) | 92 | 27 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTES

${ }^{1}$ Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
${ }^{2} \theta_{\mathrm{JA}}$ is specified for worst case mounting conditions, i.e., $\theta_{\mathrm{JA}}$ is specified for device in socket for cerdip and plastic DIP packages; $\theta_{\mathrm{JA}}$ is specified for device soldered to printed circuit board for SOIC package.

## CAUTION

1. Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation at or above this specification is not implied. Exposure to the above maximum rating conditions for extended periods may affect device reliability.
2. Digital inputs and outputs are protected; however, permanent damage may occur on unprotected units from high-energy electrostatic fields. Keep units in conductive foam or packaging at all times until ready to use. Use proper antistatic handling procedures.

3. Remove power before inserting or removing units from their sockets.

## PIN CONNECTIONS



ORDERING GUIDE

| Model $^{\mathbf{1}}$ | Temperature <br> Range | Package <br> Description | Package <br> Option $^{2}$ |
| :--- | :--- | :--- | :--- |
| SMP18FQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Cerdip | $\mathrm{Q}-16$ |
| SMP18FP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Plastic DIP | $\mathrm{N}-16$ |
| SMP18FS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | SO-16 | $\mathrm{R}-16 \mathrm{~A}$ |

## NOTES

${ }^{1}$ Consult factory for 883 data sheet.
${ }^{2}$ For outline information see Package Information section.
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SW06 - Quad SPST JFET Analog Switch ..... 7-93

Selection Tree - Switches



* Single Op Amp with Disable Function
** Triple Op Amp with Disable Function

Selection Guides-Switches and Multiplexers

## CMOS Switches

| Model | Function | Leakage Current $n A$ max | $\mathbf{R}_{\mathbf{O N}}$ Ohms max | Latched | Package Options ${ }^{1}$ | Temp Ranges ${ }^{2}$ | Comments | Page ${ }^{3}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ADG411 | Quad SPST | 0.25 | 35 |  | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | Second Source to DG411, Dielectrically Isolated | 7-36 |
| ADG412 | Quad SPST | 0.25 | 35 |  | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | Second Source to DG412, Dielectrically Isolated | 7-36 |
| ADG413 | Dual SPDT | 0.25 | 35 |  | N, R | I | SPDT Logic Version | 7-36 |
| ADG511 | Quad SPST | 0.25 | 50 |  | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | Specified at 3 V/5 V Supplies | 7-78 |
| ADG512 | Quad SPST | 0.25 | 50 |  | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | Specified at 3V/5 V Supplies | 7-78 |
| ADG513 | Dual SPDT | 0.25 | 50 |  | N, R | I | SPDT Logic Version | 7-78 |
| ADG441 | Quad SPST | 0.25 | 85 |  | N, Q, R | I, M | Second Source to DG441, Upgrade for DG201A/ADG201A, Dielectrically Isolated | 7-64 |
| ADG442 | Quad SPST | 0.25 | 85 |  | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | Second Source to DG442, Upgrade for DG202A/ADG201A, Dielectrically Isolated | 7-64 |
| ADG444 | Quad SPST | 0.5 | 80 |  | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | Superior Second Source to DG444, Dielectrically Isolated, Upgrade for ADG211A | 7-64 |
| ADG419 | SPDT | 0.25 | 35 |  | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | Mini-DIP SPDT Switch | 7-44 |
| ADG431 | Quad SPST | 0.25 | 24 |  | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | Improved Replacement for DG411 | 7-56 |
| ADG432 | Quad SPST | 0.25 | 24 |  | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | Improved Replacement for DG412 | 7-56 |
| ADG433 | Dual SPDT | 0.25 | 24 |  | N, R | I | SPDT Logic Version | 7-56 |
| ADG201HS | Quad SPST | 1 | 50 |  | $\mathbf{E}, \mathbf{N}, \mathbf{P}, \mathbf{Q}, \mathbf{R}$ | C, I, M/D | High Speed Quad Switch, 44 V Supply Maximum Ratings | 7-14 |
| ADG201A | Quad SPST | 1-2 | 90 |  | $\mathbf{E}, \mathbf{N}, \mathbf{P}, \mathbf{Q}, \mathbf{R}$ | C, I, M/ | 44 V Supply Maximum Ratings | 7-10 |
| ADG202A | Quad SPST | 1-2 | 90 |  | $\mathbf{E}, \mathbf{N}, \mathbf{P}, \mathbf{Q}, \mathbf{R}$ | C, I, M/ | 44 V Supply Maximum Ratings | 7-10 |
| ADG221 | Quad SPST | 1-2 | 90 | X | E, N, P, Q, R | C, I, M/ | Latched Input, 44 V Supply Maximum Ratings | CII 5-65 |
| ADG222 | Quad SPST | 1-2 | 90 | X | N, P, Q, R | C, I, M/ | Latched Input, 44 V Supply Maximum Ratings | CII 5-65 |
| AD7510DI | Quad SPST | 5-10 | 100 |  | N, P, Q, R | C, $\mathrm{M}_{\mathrm{D}}$ | DiCMOS, Dielectrically Isolated | CII 5-17 |
| AD7511DI | Quad SPST | 5-10 | 100 |  | N, P, Q, R | C, M/D | DiCMOS, Dielectrically Isolated | CII 5-17 |
| AD7590DI | Quad SPST | 5 | 90 | X | N, P, Q, R | C, I, M/D | DiCMOS, Latched Input, Dielectrically Isolated | CII 5-25 |
| AD7591DI | Quad SPST | 5 | 90 | X | N, P, Q, R | C, I, M/ | DiCMOS, Latched Input, Dielectrically Isolated | CII 5-25 |
| SSM2404 | Quad SPST | 20 | 45 |  | N, R | I | "Clickless" Quad Audio Switch (CBCMOS) | 14-37 |
| ADG211A | Quad SPST | 5 | 115 |  | $\mathbf{N}, \mathbf{P}, \mathbf{R}$ | C | Low Cost, 44 V Supply Maximum Ratings | 7-18 |
| ADG212A | Quad SPST | 5 | 115 |  | $\mathbf{N}, \mathbf{P}, \mathbf{R}$ | C | Low Cost, 44 V Supply Maximum Ratings | 7-18 |
| AD7512DI | Dual SPDT | 5-10 | 100 |  | E, N, P, Q | C, M/ ${ }_{\text {D }}$ | DiCMOS, Dielectrically Isolated | CII 5-17 |
| AD7592DI | Dual SPDT | 5 | 90 | X | E, N, P, Q | C, M/ | DiCMOS, Latched Input, Dielectrically Isolated | CII 5-25 |

[^88]
## Bipolar JFET Switches

| Model | Function | Leakage Current nA max | $\mathbf{R}_{\mathbf{O N}}$ Ohms max | Package Options ${ }^{1}$ | Temp Ranges ${ }^{2}$ | Comments | Page ${ }^{3}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SW06 | Quad SPST | 2.0 | 80 | $\mathbf{E}, \mathbf{N}, \mathbf{P}, \mathbf{Q}$ | I, $\mathbf{M}_{\mathbf{D}}$ | Improved LF11333/13333, Configures to 2X SPDT \& DPDT | 7-93 |
| SW201 | Quad SPST | 10.0 | 150 | N, R | I, M/ | Improved Low Cost DG201 | CII 5-161 |
| SW202 | Quad SPST | 10.0 | 150 | N, R | I | Improved Low Cost DG202 | CII 5-161 |
| SSM2402 | Dual SPST | 10.0 | 85 | N, $\mathbf{R}$ | I | "Clickless" Bilateral Audio Switch | 14-37 |
| SSM2412 | Dual SPST | 10.0 | 85 | $\mathbf{N}, \mathbf{R}$ | I | Fast, Dual Audio Switch | 14-34 |




 temperature designator will be followed by: / to indicate $883 \mathrm{~B},{ }_{\mathrm{J}}$ for JAN, ${ }_{\mathrm{D}}$ for SMD, and ${ }_{\mathrm{s}}$ for space level.
CII = Data Converter Reference Manual, Volume II. All other entries refer to this volume.
Boldface Type: Data sheet information in this volume

## Selection Guides-Switches and Multiplexers

## CMOS Multiplexers

| Model | Function | Leakage Current nA max | $\begin{aligned} & \mathbf{R}_{\text {ON }} \text { Ohms } \\ & \text { max } \end{aligned}$ | Latched | Package Options ${ }^{1}$ | Temp Ranges ${ }^{2}$ | Comments | Page ${ }^{3}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| AD75019 | 16:16 | 10 | 300 | X | P | C | $16 \times 16$ Analog Crosspoint, Serial Interface | CII 5-39 |
| ADG406 | 16:1 | 0.5 | 80 |  | N, P | I | Superior Second Source to DG406 | 7-22 |
| ADG426 | 16:1 | 0.5 | 80 | X | N, RS | I | Plug-In Upgrade for DG526 | 7-22 |
| ADG428 | 16:1 | 0.5 | 100 | X | $\mathbf{N}, \mathbf{P}, \mathbf{Q}$ | I, M | Superior Second Source to DG428 | 7-48 |
| ADG506A | 16:1 | 1 | 280 |  | E, N, P, Q, R | C, I, M/ ${ }_{\text {D }}$ | Superior Second Source to DG506A | CII 5-79 |
| ADG526A | 16:1 | 1 | 280 | X | E, N, P, Q, R | C, I, M/D | Superior Second Source to DG526A | CII 5-95 |
| ADG407 | Diff. 8:1 | 0.5 | 80 |  | N, P | I | Superior Second Source to DG407 | 7-22 |
| ADG429 | Diff. 8:1 | 0.5 | 100 | X | $\mathbf{N}, \mathbf{P}, \mathbf{Q}$ | I, M | Superior Second Source to DG429 | 7-48 |
| ADG507A | Diff. 8:1 | 1 | 280 |  | E, N, P, Q, R | C, I, M/ ${ }_{\text {D }}$ | Superior Second Source to DG507A | CII 5-79 |
| ADG527A | Diff. 8:1 | 1 | 280 | X | E, N, P, Q, R | C, I, M/D | Superior Second Source to DG527A | CII 5-95 |
| ADG408 | 8:1 | 0.5 | 100 |  | $\mathbf{E}, \mathbf{N}, \mathbf{Q}$ | C, I, M | Superior Second Source to DG408 | 7-28 |
| ADG508A | 8:1 | 1 | 300 |  | $\mathbf{E}, \mathbf{N}, \mathbf{P}, \mathbf{Q}, \mathbf{R}$ | C, I, M/ ${ }_{\text {D }}$ | Superior Second Source to DG508A | 7-70 |
| ADG508F | 8:1 | 0.5 | 300 |  | $\mathbf{N}, \mathbf{P}, \mathbf{Q}, \mathbf{R}$ | I, M | Fault Protected | 7-74 |
| ADG528F | 8:1 | 0.5 | 300 | $\mathbf{X}$ | $\mathbf{N}, \mathbf{P}, \mathbf{Q}$ | I, M | Fault Protected | 7-74 |
| ADG528A | 8:1 | 1 | 300 | X | E, N, P, Q, | C, I, M/ ${ }_{\text {D }}$ | Superior Second Source to DG528A | CII 5-103 |
| ADG409 | Diff. 4:1 | 0.5 | 100 |  | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M | Superior Second Source to DG409 | 7-28 |
| ADG509A | Diff. 4:1 | 1 | 300 |  | $\mathbf{E}, \mathbf{N}, \mathbf{P}, \mathbf{Q}, \mathbf{R}$ | C, I, M/ ${ }_{\text {D }}$ | Superior Second Source to DG509A | 7-70 |
| ADG509F | Diff. 4:1 | 0.5 | 300 | X | $\mathbf{N}, \mathbf{P}, \mathbf{Q}, \mathbf{R}$ | I, M | Fault Protected | 7-74 |
| ADG529F | Diff. 4:1 | 0.5 | 300 | X | $\mathbf{N}, \mathbf{P}, \mathbf{Q}$ | I, M | Fault Protected | 7-74 |
| ADG529A | Diff. 4:1 | 1 | 300 | X | E, N, P, Q | C, I, M/D | Superior Second Source to DG529A | CII 5-103 |

## Bipolar JFET Multiplexers

| Model | Function | Leakage Current nA max | $\mathbf{R}_{\text {ON }}$ Ohms max | Package Options ${ }^{1}$ | Temp Ranges ${ }^{2}$ | Comments | Page ${ }^{3}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| MUX08 | 8:1 | 1.0 | 300 | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, $\mathrm{I}, \mathrm{M} / \mathrm{D}$ | Improved DG508 | 7-87 |
| MUX16 | 16:1 | 1.0 | 380 | E, $\mathbf{N}, \mathbf{P}, \mathbf{Q}$ | $\mathrm{I}, \mathrm{M} / \mathrm{D}$ | Improved DG506 | 7-90 |
| MUX24 | Diff. 4:1 | 1.0 | 300 | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | $\mathbf{C}, \mathrm{I}, \mathrm{M} / \mathrm{D}$ | Improved DG509 | 7-87 |
| MUX28 | Diff. 8:1 | 1.0 | 380 | $\mathbf{E}, \mathbf{N}, \mathbf{P}, \mathbf{Q}$ | I, M/ | Improved DG507 | 7-90 |

## Video Multiplexer

| Model | Function | Full Power BW MHz min | Crosstalk Rejection F $=10 \mathrm{MHz} \mathrm{dB}$ | Package Options ${ }^{1}$ | Temp Ranges ${ }^{2}$ | Comments | Page ${ }^{3}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| AD9300 | 4:1 | 30 | 75 | $\mathbf{E}, \mathbf{Q}$ | C, M/ | Wideband Video Mux | 7-7 |

[^89]AD9300

## FEATURES

34MHz Full Power Bandwidth
$\pm 0.1 \mathrm{~dB}$ Gain Flatness to $\mathbf{8 M H z}$
72dB Crosstalk Rejection @ 10MHz
0.03 $\%$ 0.01\% Differential Phase/Gain

Cascadable for Switch Matrices
MIL-STD-883 Compliant Versions Available

## APPLICATIONS

Video Routing
Medical Imaging
Electro-Optics
ECM Systems
Radar Systems
Data Acquisition

## GENERAL DESCRIPTION

The AD9300 is a monolithic high-speed video signal multiplexer useable in a wide variety of applications.
Its four channels of video input signals can be randomly switched at megahertz rates to the single output. In addition, multiple devices can be configured in either parallel or cascade arrangements to form switch matrices. This flexibility in using the AD9300 is possible because the output of the device is in a high-impedance state when the chip is not enabled; when the chip is enabled, the unit acts as a buffer with a high input impedance and low output impedance.

An advanced bipolar process provides fast, wideband switching capabilities while maintaining crosstalk rejection of 72 dB at 10 MHz . Full power bandwidth is a minimum 27 MHz . The device can be operated from $\pm 10 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$ power supplies.

FUNCTIONAL BLOCK DIAGRAM
(Based on Cerdip)


The AD9300K is available in a 16 -pin ceramic DIP and a $20-$ pin PLCC and is designed to operate over the commercial temperature range of 0 to $+70^{\circ} \mathrm{C}$. The AD9300TQ is a hermetic 16 -pin ceramic DIP for military temperature range ( $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ ) applications. This part is also available processed to MIL-STD883. The AD9300 is available in a 20 -pin LCC as the model AD9300TE, which operates over a temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.

The AD9300 Video Multiplexer is available in versions compliant with MIL-STD-883. Refer to the Analog Devices Military Products Databook or current AD9300/883B data sheet for detailed specifications.

PIN DESIGNATIONS


This is an abridged data sheet. To obtain the most recent version or complete data sheet, cell our fax retrieval system at 1-800-446-6212.


| Parameter(Conditions) | Temp | Test <br> Level | Min | MER <br> to +70 <br> 300KQ <br> Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT CHARACTERISTICS |  |  |  |  |  |  |
| Input Offset Voltage | $+25^{\circ} \mathrm{C}$ | I |  | 3 | 10 | mV |
| Input Offset Voltage | Full | VI |  |  | 14 | mV |
| Input Offset Voltage Drift ${ }^{2}$ | Full | V |  | 75 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Bias Current | $+25^{\circ} \mathrm{C}$ | I |  | 15 | 37 | $\mu \mathrm{A}$ |
| Input Bias Current | Full | VI |  |  | 55 | $\mu \mathrm{A}$ |
| Input Resistance | $+25^{\circ} \mathrm{C}$ | V |  | 3.0 |  | $\mathrm{M} \Omega$ |
| Input Capacitance | $+25^{\circ} \mathrm{C}$ | V |  | 2 |  | pF |
| Input Noise Voltage (dc to 8 MHz ) | $+25^{\circ} \mathrm{C}$ | V |  | 16 |  | $\mu \mathrm{Vrms}$ |
| TRANSFER CHARACTERISTICS |  |  |  |  |  |  |
| Voltage Gain ${ }^{3}$ | $+25^{\circ} \mathrm{C}$ | I | 0.990 | 0.994 |  | V/V |
| Voltage Gain ${ }^{3}$ | Full | VI | 0.985 |  |  | V/V |
| DCLinearity ${ }^{4}$ | $+25^{\circ} \mathrm{C}$ | V |  | 0.01 |  | \% |
| Gain Tolerance ( $\left.\mathrm{V}_{\text {IN }}= \pm 1 \mathrm{~V}\right)$ |  |  |  |  |  |  |
| dc to 5 MHz | $+25^{\circ} \mathrm{C}$ | I |  | 0.05 | 0.1 | dB |
| 5 MHz to 8 MHz | $+25^{\circ} \mathrm{C}$ | I |  | 0.1 | 0.3 | dB |
| Small-Signal Bandwidth $\left(\mathrm{V}_{\mathrm{IN}}=100 \mathrm{mV} \mathrm{p}-\mathrm{p}\right)$ | $+25^{\circ} \mathrm{C}$ | V |  | 350 |  | MHz |
| Full Power Bandwidth ${ }^{5}$ $\left(\mathrm{V}_{\mathrm{IN}}=2 \mathrm{~V} p-\mathrm{p}\right)$ | $+25^{\circ} \mathrm{C}$ | I | 27 | 34 |  | MHz |
| Output Swing | Full | VI | $\pm 2$ |  |  | V |
| Output Current (Sinking @ $=25^{\circ} \mathrm{C}$ ) | $+25^{\circ} \mathrm{C}$ | V |  | 5 |  | mA |
| Output Resistance | $+25^{\circ} \mathrm{C}$ | IV,V |  | 9 | 15 | $\Omega$ |
| DYNAMICCHARACTERISTICS |  |  |  |  |  |  |
| Slew Rate ${ }^{6}$ | $+25^{\circ} \mathrm{C}$ | I | 170 | 215 |  | V/us |
| Settling Time (to $0.1 \%$ on $\pm 2 \mathrm{~V}$ Output) | $+25^{\circ} \mathrm{C}$ | IV |  | 70 | 100 | ns |
| Overshoot |  |  |  |  |  |  |
| To T-Step ${ }^{7}$ | $+25^{\circ} \mathrm{C}$ | V |  | $<0.1$ |  | \% |
| To Pulse ${ }^{8}$ | $+25^{\circ} \mathrm{C}$ | V |  | $<10$ |  | \% |
| Differential Phase ${ }^{9}$ | $+25^{\circ} \mathrm{C}$ | IV |  | 0.03 | 0.1 | 。 |
| Differential Gain ${ }^{9}$ | $+25^{\circ} \mathrm{C}$ | IV |  | 0.01 | 0.1 | \% |
| Crosstalk Rejection |  |  |  |  |  |  |
| Three Channels ${ }^{10}$ | $+25^{\circ} \mathrm{C}$ | IV | 68 | 72 |  | dB |
| One Channel ${ }^{11}$ | $+25^{\circ} \mathrm{C}$ | IV | 70 | 76 |  | dB |
| SWITCHING CHARACTERISTICS ${ }^{12}$ |  |  |  |  |  |  |
| Ax $^{\text {Input to Channel HIGH Time }}{ }^{13}$ ( $\mathbf{t}_{\mathrm{HIGH}}$ ) | $+25^{\circ} \mathrm{C}$ | I |  | 40 | 50 | ns |
| $\mathrm{A}_{\mathrm{X}}$ Input to Channel LOW Time ${ }^{14}$ (t Low ) | $+25^{\circ} \mathrm{C}$ | I |  | 35 | 45 | ns |
| Enable to Channel ON Time ${ }^{15}$ $\left(\mathrm{t}_{\mathrm{ON}}\right)$ | $+25^{\circ} \mathrm{C}$ | I |  | 35 | 45 | ns |
| Enable to Channel OFF Time ${ }^{16}$ ( $\mathrm{t}_{\mathrm{OFF}}$ ) | $+25^{\circ} \mathrm{C}$ | I |  | 35 | 45 | ns |
| Switching Transient ${ }^{17}$ | $+25^{\circ} \mathrm{C}$ | V |  | 60 |  | mV |

## EXPLANATION OF TEST LEVELS

Test Level I
Test Level II
Test Level III
Test Level IV
Test Level V
Test Level VI

- $100 \%$ production tested.
- $100 \%$ production tested at $+25^{\circ} \mathrm{C}$, and sample tested at specified temperatures.
- Sample tested only.
- Parameter is guaranteed by design and characterization testing.
- Parameter is a typical value only.
- All devices are $100 \%$ production tested at $+25^{\circ} \mathrm{C} .100 \%$ production tested at temperature extremes for military temperature devices; sample tested at temperature extremes for commercial/industrial devices.

| Parameter (Conditions) | Temp | Test Level | $\begin{gathered} \text { COMMERCIAL } \\ 0^{\circ} \mathrm{C} \text { to }+70^{\circ} \mathrm{C} \\ \text { AD9300KQ/KP } \end{gathered}$ |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max |  |
| DIGITAL INPUTS |  |  |  |  |  |  |
| Logic " 1 " Voltage | Full | VI | 2 |  |  | V |
| Logic " 0 " Voltage | Full | VI |  |  | 0.8 | V |
| Logic " 1 " Current | Full | VI |  |  | 5 | $\mu \mathrm{A}$ |
| Logic "0" Current | Full | VI |  |  | 1 | $\mu \mathrm{A}$ |
| POWER SUPPLY |  |  |  |  |  |  |
| Positive Supply Current ( +12 V ) | $+25^{\circ} \mathrm{C}$ | I |  | 13 | 16 | mA |
| Positive Supply Current ( +12 V ) | Full | VI |  | 13 | 16 | mA |
| Negative Supply Current ( -12 V ) | $+25^{\circ} \mathrm{C}$ | I |  | 12.5 | 15 | mA |
| Negative Supply Current ( -12 V ) | Full | VI |  | 12.5 | 16 | mA |
| Power Supply Rejection Ratio $\left( \pm V_{S}= \pm 12 \mathrm{~V} \pm 5 \%\right)$ | Full | VI | 67 | 75 |  | dB |
| Power Dissipation ( $\pm 12 \mathrm{~V})^{18}$ | $+25^{\circ} \mathrm{C}$ | V |  | 306 |  | mW |

NOTES
${ }^{1}$ Permanent damage may occur if any one absolute maximum rating is exceeded. Functional operation is not implied, and device reliability may be impaired by exposure to higher-than-recommended voltages for extended periods of time.
${ }^{2}$ Measured at extremes of temperature range.
${ }^{3}$ Measured as slope of $\mathrm{V}_{\text {OUT }}$ versus $\mathrm{V}_{\text {IN }}$ with $\mathrm{V}_{\text {IN }}= \pm 1 \mathrm{~V}$.
${ }^{4}$ Measured as worst deviation from end-point fit with $\mathrm{V}_{\text {IN }}= \pm 1 \mathrm{~V}$.
${ }^{5}$ Full Power Bandwith (FPBW) based on Slew Rate (SR). FPBW $=\mathrm{SR} / 2 \pi \mathrm{~V}_{\text {PEAK }}$
${ }^{6}$ Measured between $20 \%$ and $80 \%$ transition points of $\pm 1 \mathrm{~V}$ output.
${ }^{7} \mathrm{~T}$-Step $=\operatorname{Sin}^{2} \mathrm{X}$ Step, when Step between 0 V and +700 mV points has $10 \%$-to- $90 \%$ risetime $=125 \mathrm{~ns}$.
${ }^{8}$ Measured with a pulse input having slew rate $>250 \mathrm{~V} / \mu \mathrm{s}$.
${ }^{9}$ Measured at output between 0.28 Vdc and 1.0 Vdc with $\mathrm{V}_{\mathrm{IN}}=284 \mathrm{mV}$ p-p at 3.58 MHz and 4.43 MHz .
${ }^{10}$ This specification is critically dependent on circuit layout. Value shown is measured with selected channel grounded and 10 MHz 2 V p-p signal applied to remaining three channels. If selected channel is grounded through $75 \Omega$, value is approximately 6 dB higher.
${ }^{11}$ This specification is critically dependent on circuit layout. Value shown is measured with selected channel grounded and 10 MHz 2 V p-p signal applied to one other channel. If selected channel is grounded through $75 \Omega$, value is approximately 6 dB higher. Minimum specification in () applies to DIPs.
${ }^{12}$ Consult system timing diagram.
${ }^{13}$ Measured from address change to $90 \%$ point of -2 V to +2 V output LOW-to-HIGH transition.
${ }^{14}$ Measured from address change to $90 \%$ point of +2 V to -2 V output HIGH-to-LOW transition.
${ }^{15}$ Measured from $50 \%$ transition point of ENABLE input to $90 \%$ transition of 0 V to -2 V and 0 V to +2 V output.
${ }^{16}$ Measured from $50 \%$ transition point of ENABLE input to $10 \%$ transition of +2 V to 0 V and -2 V to 0 V output.
${ }^{17}$ Measured while switching between two grounded channels.
${ }^{18}$ Maximum power dissipation is a package-dependent parameter related to the following typical thermal impedances: $16-$ Pin Ceramic $\theta_{\mathrm{JA}}=87^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=25^{\circ} \mathrm{C} / \mathrm{W}$ 20-Pin LCC $\quad \theta_{\mathrm{JA}}=74^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=10^{\circ} \mathrm{C} / \mathrm{W}$ $20-\mathrm{Pin}$ PLCC $\quad \theta_{\mathrm{JA}}=71^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=26^{\circ} \mathrm{C} / \mathrm{W}$
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

Supply Voltages ( $\pm \mathrm{V}_{\mathrm{s}}$ ) . . . . . . . . . . . . . . . . . $\pm 16 \mathrm{~V}$
Analog Input Voltage Each Input

$$
\begin{aligned}
& \text { ( } \mathrm{IN}_{1} \text { thru } \mathrm{IN}_{4} \text { ) } \\
& \pm 3.5 \mathrm{~V}
\end{aligned}
$$

Differential Voltage Between Any Two
Inputs ( $\mathrm{IN}_{1}$ thru $\mathrm{IN}_{4}$ )
5V
Digital Input Voltages ( $\mathrm{A}_{0}, \mathrm{~A}_{1}$, ENABLE) . -0.5 V to +5.5 V

Output Current
Sinking . . . . . . . . . . . . . . . . . . . . . . . . 6.0mA
Sourcing . . . . . . . . . . . . . . . . . . . . . . . 6.0 mA
Operating Temperature Range
AD9300KQ/KP $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Junction Temperature . . . . . . . . . . . . . . . . . $+175^{\circ} \mathrm{C}$
Lead Soldering (10sec) . . . . . . . . . . . . . . . . $+300^{\circ} \mathrm{C}$

ORDERING GUIDE

| Device | Temperature Range | Description | Package Option ${ }^{1}$ |
| :---: | :---: | :---: | :---: |
| AD9300KQ | 0 to $+70^{\circ} \mathrm{C}$ | 16-Pin Cerdip, Commercial | Q-16 |
| AD9300TE/883B ${ }^{2}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 20-Pin LCC, Military Temperature | E-20A |
| AD9300TQ/883B ${ }^{2}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 16-Pin Cerdip, Military Temperature | Q-16 |
| AD9300KP | 0 to $+70^{\circ} \mathrm{C}$ | 20-Pin PLCC, Commercial | P-20A |

[^90]
## FEATURES

44V Supply Maximum Rating
$\pm 15 \mathrm{~V}$ Analog Signal Range
Low Row (60ת)
Low Leakage (0.5nA)
Break Before Make Switching
Extended Plastic Temperature Range ( $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ )
Low Power Dissipation (33mW)
Available in 16-Lead DIP/ SOIC and 20-Lead PLCC/LCCC Packages
Superior Second Source: ADG201A Replaces DG201A, HI-201 ADG202A Replaces DG202


## PRODUCT HIGHLIGHTS

1. Extended Signal Range:

These switches are fabricated on an enhanced $\mathrm{LC}^{2}$ MOS process, resulting in high breakdown and an increased analog signal range of $\pm 15 \mathrm{~V}$.
2. Single Supply Operation:

For applications where the analog signal is unipolar ( 0 V to 15 V ), the switches can be operated from a single +15 V supply.
3. Low Leakage:

Leakage currents in the range of 500 pA make these switches suitable for high precision circuits. The added feature of Break before Make allows for multiple outputs to be tied together for multiplexer applications while keeping leakage errors to a minimum.
$\left(V_{D D}=+15 V, V_{S S}=-15 V\right.$, unless otherwise specified)


## NOTES

${ }^{1}$ Sample tested at $25^{\circ} \mathrm{C}$ to ensure compliance.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUMRATINGS*

( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise stated)

| $\mathrm{V}_{\mathrm{DD}}$ to $\mathrm{V}_{\text {ss }}$ | 44 V |
| :---: | :---: |
| $V_{\text {DD }}$ to GND | 25V |
| $\mathrm{V}_{\text {ss }}$ to GND | -25V |
| Analog Inputs ${ }^{1}$ |  |
| Voltage at S, D | $\mathrm{V}_{\text {ss }}-0.3 \mathrm{~V}$ to |
|  | $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| Continuous Current, S or D | 30 mA |
| Pulsed Current Sor D |  |
| 1ms Duration, 10\% Duty Cycle | 70 mA |
| Digital Inputs ${ }^{1}$ |  |
| Voltage at IN | $\mathrm{V}_{\text {ss }}-2 \mathrm{~V}$ to |
|  | $\mathrm{V}_{\mathrm{DD}}+2 \mathrm{~V}$ or |


| Power Dissipation (Any Package) |  |
| :---: | :---: |
| Up to $+75^{\circ} \mathrm{C}$ | 470mW |
| Derates above $+75^{\circ} \mathrm{C}$ by | $6 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ |
| Operating Temperature |  |
| Commercial (K Version) | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Industrial (B Version) | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Extended (TVersion) | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Lead Temperature (Soldering 10sec) | $+300^{\circ} \mathrm{C}$ |

NOTE
${ }^{1}$ Overvoltage at IN, S or D will be clamped by diodes. Current should be limited to the Maximum Rating above.

[^91]
## CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are removed.

## WARNING!

ORDERING GUIDE

|  | Temperature <br> Range | Package <br> Option |
| :--- | :--- | :--- |
| ADG201AKN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| ADG201AKR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | R-16A |
| ADG201AKP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{P}-20 \mathrm{~A}$ |
| ADG201ABQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| ADG201ATQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| ADG201ATE | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{E}-20 \mathrm{~A}$ |
| ADG202AKN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| ADG202AKR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16 \mathrm{~A}$ |
| ADG202AKP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{P}-20 \mathrm{~A}$ |
| ADG202ABQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| ADG202ATQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| ADG202ATE | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{E}-20 \mathrm{~A}$ |

NOTES
${ }^{1}$ To order MIL-STD-883, Class B processed parts, add /883B to T grade part numbers. See Analog Devices Military Products Databook (1990) for military data sheet.
${ }^{2} \mathrm{~N}=$ Plastic DIP; $\mathrm{R}=0.15^{\prime \prime}$ Small Outline IC (SOIC); $\mathbf{P}=$ Plastic Leaded Chip Carrier (PLCC); Q = Cerdip; E = Leadless Ceramic Chip Carrier (LCCC). For outline information see Package Information section.

## PIN CONFIGURATIONS



ADG201A/ADG202A FUNCTIONAL DIAGRAM



Figure 1. Typical Digital Input Cell

## Typical Performance Characteristics

ADG201A/ADG202A
The switches are guaranteed functional with reduced single or dual supplies down to 4.5V .

$R_{O N}$ as a Function of $V_{D}\left(V_{S}\right)$ : Dual Supply Voltage


Leakage Current as a Function of Temperature (Note: Leakage Currents Reduce as the Supply Voltages Reduce)


Switching Time vs. Supply Voltage (Dual Supply)

$R_{O N}$ as a Function of $V_{D}\left(V_{S}\right)$ : Single Supply Voltage


Trigger Level vs. Power Supply Voltage: Dual or Single Supply Voltage


Switching Time vs. Supply Voltage (Single Supply)

```
FEATURES
50ns max Switching Time Over Full Temperature
        Range
Low RoN (30\Omega typ)
Single Supply Specifications for +10.8V to
    +16.5V Operation
Extended Plastic Temperature Range
    (-40}\mp@subsup{}{}{\circ}\textrm{C}\mathrm{ to +85}\mp@subsup{}{}{\circ}\textrm{C}
Break-Before-Make Switching
Low Leakage (100pA typ)
44V Supply max Rating
Available in 16-Lead DIP/SOIC and
    20-Lead LCCC/PLCC Packages
ADG201HS (K, B, T) Replaces HI-201HS
ADG201HS (J, A, S) Replaces DG271
```


## GENERAL DESCRIPTION

The ADG201HS is a monolithic CMOS device comprising four independently selectable SPST switches. It is designed on an enhanced LC ${ }^{2}$ MOS process which gives very fast switching speeds and low $\mathrm{R}_{\mathrm{ON}}$.
The switches also feature break-before-make switching action for use in multiplexer applications and low charge injection for minimum transients on the output when switching the digital inputs.

ORDERING GUIDE

|  | Temperature <br> Range | Package <br> Option |
| :--- | :--- | :--- |
| ADG201HSJN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| ADG201HSKN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| ADG201HSKR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16$ |
| ADG201HSAQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| ADG201HSBQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| ADG201HSJP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{P}-20 \mathrm{~A}$ |
| ADG201HSKP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{P}-20 \mathrm{~A}$ |
| ADG201HSSQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| ADG201HSTQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| ADG201HSTE ${ }^{3}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{E}-20 \mathrm{~A}$ |

## NOTES

${ }^{1}$ To order MIL-STD-883, Class B processed parts, add /883B to T grade part numbers. See the Analog Devices Military Products Databook (1994) for military data sheet. ${ }^{2} \mathrm{E}=$ Leadless Ceramic Chip Carrier; $\mathrm{N}=$ Narrow Plastic DIP; $\mathbf{P}=$ Plastic Leaded Chip Carrier; $\mathbf{Q}=$ Cerdip; $R=0.15^{\prime \prime}$ Small Outline IC (SOIC). For outline information see Package Information section.
${ }^{3}$ Standard Military Drawing (SMD) approved by DESC.
SMD numbers are
5962-86716012X (ADG201HSTE/883B) 5962-8671601EX (ADG201HSTQ/883B)

FUNCTIONAL BLOCK DIAGRAM


## PRODUCT HIGHLIGHTS

1. 50 ns max $t_{\mathrm{ON}}$ and $\mathrm{t}_{\mathrm{OFF}}$ :

The ADG201HS top grades (K, B, T) have guaranteed 50ns max turn-on and turn-off times over the full operating temperature range. The lower grades ( $\mathrm{J}, \mathrm{A}, \mathrm{S}$ ) have guaranteed $75 n$ switching times over the full operating temperature range.
2. Single Supply Specifications:

The ADG201HS is fully specified for applications which require a single positive power supply in the +10.8 V to +16.5 V range.
3. Low Leakage:

Leakage currents in the range of 100 pA make these switches suitable for high precision circuits. The added feature of break-before-make allows for multiple outputs to be tied together for multiplexer applications while keeping leakage errors to a minimum.


Truth Table

This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

DUAL SUPPLY $\begin{aligned} & \left(V_{D D}=+13.5 V \text { to }+16.5 \mathrm{~V},=-13.5 \mathrm{~V} \text { to }-16.5 \mathrm{~V}, \mathrm{GND}=0 \mathrm{~V},\right. \\ & \mathrm{V}_{\mathrm{IN}} 3 \mathrm{~V} \text { [Logic High Level] or } 0.8 \mathrm{~V} \text { [Logic Low Level] unless otherwise noted) }\end{aligned}$

| Parameter | Version | $+25^{\circ} \mathrm{C}$ | $\mathrm{T}_{\text {min }}-\mathrm{T}_{\text {max }}{ }^{1}$ | Units | Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| ANALOG SWITCH |  |  |  |  |  |
| Analog Signal Range | All | $\mathrm{V}_{\text {ss }}$ | $\mathrm{V}_{\text {ss }}$ | Vmin |  |
|  | All | $\mathrm{V}_{\text {DD }}$ | $\mathrm{V}_{\text {DD }}$ | $V_{\text {max }}$ |  |
| $\mathrm{R}_{\text {ON }}$ | All | 30 | - | $\Omega$ typ | $-10 \mathrm{~V} \leqslant \mathrm{~V}_{S} \leqslant+10 \mathrm{~V}, \mathrm{I}_{\mathrm{DS}}=1 \mathrm{~mA} ;$ Test Circuit 1 |
|  | All | 50 | 75 | $\Omega$ max |  |
| $\mathrm{R}_{\text {ON }}$ Drift | All | 0.5 | - | \%/ ${ }^{\circ} \mathrm{Ctyp}$ | $-10 \mathrm{~V} \leqslant \mathrm{~V}_{S} \leqslant+10 \mathrm{~V}, \mathrm{I}_{\mathrm{DS}}=1 \mathrm{~mA}$ |
| $\mathrm{R}_{\text {ON }}$ Match | All | 3 | - | \% typ | $-10 \mathrm{~V} \leqslant \mathrm{~V}_{S} \leqslant+10 \mathrm{~V}, \mathrm{I}_{\text {DS }}=1 \mathrm{~mA}$ |
| $\mathrm{I}_{5}$ (OFF), Off Input Leakage ${ }^{2}$ | All | 0.1 |  | nA typ | $\mathrm{V}_{\mathrm{D}}= \pm 14 \mathrm{~V} ; \mathrm{V}_{\mathrm{S}}=\mp 14 \mathrm{~V} ;$ Test Circuit 2 |
|  | J, K, A, B | 1 | 20 | $n A$ max |  |
|  | S, T | 1 | 60 | $n A$ max |  |
| $\mathrm{I}_{\mathrm{D}}$ (OFF), Off Output Leakage ${ }^{\mathbf{2}}$ | All | 0.1 |  | nA typ | $\mathrm{V}_{\mathrm{D}}= \pm 14 \mathrm{~V} ; \mathrm{V}_{\mathrm{S}}=\mp 14 \mathrm{~V} ;$ Test Circuit 2 |
|  | J, K, A, B | 1 | 20 | $n A$ max |  |
|  | S,T | 1 | 60 | $n A$ max |  |
| $\mathrm{I}_{\mathrm{D}}(\mathrm{ON})$, On Channel Leakage ${ }^{2}$ | All | 0.1 |  | nA typ | $\mathrm{V}_{\mathrm{D}}=\mathrm{V}_{\text {S }}= \pm 14 \mathrm{~V}$; Test Circuit 3 |
|  | J, K, A, B | 1 | 20 | $n A$ max |  |
|  | S,T | 1 | 60 | $n A$ max |  |
| DIGITALCONTROL |  |  |  |  |  |
| $\mathrm{V}_{\text {INH }}$, Input High Voltage | All | 2.4 | 2.4 | $V$ min |  |
| $\mathrm{V}_{\text {INL }}$, Input Low Voltage | All | 0.8 | 0.8 | $V$ max |  |
| $\mathrm{I}_{\text {NNL }}$ or $\mathrm{I}_{\mathbf{N H}}$ | All | 1 | 1 | $\mu \mathrm{A}$ max |  |
| $\mathrm{C}_{\text {IN }}$ | All | 8 | 8 | pF max |  |
| DYNAMICCHARACTERISTICS |  |  |  |  |  |
| $\mathrm{t}_{\mathrm{ON}}$ | K, B, T | 50 | 50 | ns max | Test Circuit 4 |
|  | J, A, S | 75 | 75 | ns max |  |
| $\mathrm{t}_{\text {OFF } 1}$ | K, B, T | 50 | 50 | ns max | Test Circuit 4 |
|  | J, A, S | 75 | 75 | ns max |  |
| $\mathrm{t}_{\text {OFF2 }}$ | All | 150 | - | ns typ | Test Circuit 4 |
| topen | All | 5 | 5 | nstyp | $\mathrm{t}_{\text {ON }}-\mathrm{t}_{\text {OfFl }}$; Test Circuit 4 |
| Output Settling Time to 0.1\% | All | 180 | - | nstyp | $\mathrm{V}_{\text {IN }}=3 \mathrm{~V}$ to 0V; Test Circuit 4 |
| OFF Isolation | All | 72 | - | dB typ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=3 \mathrm{Vrms}, \mathrm{f}=100 \mathrm{kHz}, \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega ; \\ & \mathrm{C}_{\mathrm{L}}=10 \mathrm{pF} ; \text { Test Circuit } 5 \end{aligned}$ |
| Channel-to-Channel Crosstalk | All | 86 | - | dB typ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=3 \mathrm{~V} \mathrm{rms}, \mathrm{f}=100 \mathrm{kHz}, \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega ; \\ & \mathrm{C}_{\mathrm{L}}=10 \mathrm{pF} ; \text { Test Circuit } 6 \end{aligned}$ |
| Qinj, Charge Injection | All | 10 | - |  | $\mathrm{R}_{\mathbf{S}}=0 \Omega, \mathrm{~V}_{\mathrm{S}}=0 \mathrm{~V}$; Test Circuit 7 |
| $\mathrm{C}_{S}$ (OFF) | All | 10 | - | pF typ |  |
| $\mathrm{C}_{\mathrm{D}}$ (OFF) | All | 10 | - | pFtyp |  |
| $\mathrm{C}_{\mathrm{D}}, \mathrm{C}_{S}(\mathrm{ON})$ | All | 30 | - | pF typ |  |
| $\mathrm{C}_{\mathrm{DS}}$ (OFF) | All | 0.5 | - | pF typ | \% |
| POWER SUPPLY |  |  |  |  |  |
| $\mathrm{I}_{\mathrm{DD}}$ | All | 10 | 10 | $\mathrm{mA}_{\text {max }}$ |  |
| $\mathrm{I}_{\text {ss }}$ | All | 6 | 6 | mA max |  |
| Power Dissipation | All | 240 | 240 | mW max | $\mathrm{V}_{\mathrm{DD}}=+15 \mathrm{~V}, \mathrm{~V}_{\text {SS }}=-15 \mathrm{~V}$ |

## NOTES

${ }^{1}$ Temperature ranges are as follows: ADG201 $\mathrm{HSJ}, \mathrm{K} ;-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
ADG201HSA, B; $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
ADG201HSS, T; $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
${ }^{2}$ Leakage specifications apply with a $V_{D}\left(V_{S}\right)$ of $\pm 14 \mathrm{~V}$ or with a $V_{D}\left(V_{S}\right)$ of 0.5 V within the supply voltages $\left(V_{D D}, V_{S S}\right)$, whichever is the minimum.
Specifications subject to change without notice.

SINGLE SJPPLY $V_{D 0}=+10.8 \mathrm{~V}$ to $+16.5 \mathrm{~V}, \mathrm{~V}_{S S}=\mathbf{G N D}=0 \mathrm{~V}, \mathrm{~V}_{\mathbb{W}}=3 \mathrm{~V}$ [Logic High Level] or 0.8V [Logic Low Level] unless otherwise noted)

| Parameter | Version | $+25^{\circ} \mathrm{C}$ | $\mathrm{T}_{\text {min }}-\mathrm{T}_{\text {max }}$ | Units | Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| ANALOG SWITCH |  |  |  |  |  |
| Analog Signal Range | All | $\mathrm{V}_{\text {ss }}$ | $\mathrm{V}_{\text {ss }}$ | Vmin |  |
|  | All | $V_{\text {DD }}$ | $V_{\text {DD }}$ | $V_{\text {max }}$ |  |
| Ron | All | 65 | - | $\Omega$ typ | $0 \mathrm{~V} \leqslant \mathrm{~V}_{S} \leqslant+10 \mathrm{~V}, \mathrm{I}_{\mathrm{DS}}=1 \mathrm{~mA} ;$ Test Circuit 1 |
|  | All | 90 | 120 | $\Omega$ max |  |
| $\mathrm{R}_{\text {ON }}$ Drift | All | 0.5 | - | \%/ ${ }^{\circ} \mathrm{C}$ typ | $0 \mathrm{~V} \leqslant \mathrm{~V}_{S} \leqslant+10 \mathrm{~V}, \mathrm{I}_{\mathrm{DS}}=1 \mathrm{~mA}$ |
| $\mathrm{R}_{\text {ON }}$ Match | All | 3 | - | \% typ | $0 \mathrm{~V} \leqslant \mathrm{~V}_{S} \leqslant+10 \mathrm{~V}, \mathrm{I}_{\mathrm{DS}}=1 \mathrm{~mA}$ |
| $\mathrm{I}_{\mathrm{S}}$ (OFF), Off Input Leakage ${ }^{1}$ | All | 0.1 |  | nA typ | $\mathrm{V}_{\mathrm{D}}=+10 \mathrm{~V} /+0.5 \mathrm{~V} ; \mathrm{V}_{\mathrm{S}}=+0.5 \mathrm{~V} /+10 \mathrm{~V}$; Test Circuit 2 |
|  | J, K, A, B | 1 | 20 | $n A$ max |  |
|  | S, T | 1 | 60 | $n A$ max |  |
| $\mathrm{I}_{\mathrm{D}}$ (OFF), Off Output Leakage ${ }^{1}$ | All | 0.1 |  | nA typ | $\mathrm{V}_{\mathrm{D}}=+10 \mathrm{~V} /+0.5 \mathrm{~V} ; \mathrm{V}_{S}=+0.5 \mathrm{~V} /+10 \mathrm{~V} ;$ Test Circuit 2 |
|  | J, K, A, B | 1 | 20 | $n A$ max |  |
|  | S, T | 1 | 60 | $n A$ max |  |
| $\mathrm{I}_{\mathrm{D}}(\mathrm{ON})$, On Channel Leakage ${ }^{1}$ | All | 0.1 |  | nA typ | $\mathrm{V}_{\mathrm{D}}=\mathrm{V}_{\mathrm{S}}=+10 \mathrm{~V} /+0.5 \mathrm{~V}$; Test Circuit 3 |
|  | J, K, A, B | 1 | 20 | $n A$ max |  |
|  | S, T | 1 | 60 | $n A$ max |  |
| DIGITALCONTROL |  |  |  |  |  |
| $\mathrm{V}_{\text {INH }}$, Input High Voltage | All | 2.4 | 2.4 | $V_{\text {min }}$ |  |
| $\mathrm{V}_{\text {INL }}$, Input Low Voltage | All | 0.8 | 0.8 | $V_{\text {max }}$ |  |
| $\mathrm{I}_{\text {INL }}$ or $\mathrm{I}_{\text {INH }}$ | All | 1 | 1 | $\mu \mathrm{A}$ max |  |
| $\mathrm{C}_{\text {IN }}$ | All | 8 | 8 | pF max |  |
| DYNAMICCHARACTERISTICS |  |  |  |  |  |
| $\mathrm{t}_{\mathrm{ON}}$ | K, B, T | 50 | 70 | ns max | Test Circuit 4 |
|  | J, A, S | 75 | 90 | ns max |  |
| $\mathrm{t}_{\text {OFF } 1}$ | K, B, T | 50 | 70 | ns max | Test Circuit 4 |
|  | J, A, S | 75 | 90 | ns max |  |
| $t_{\text {OFF2 }}$ | All | 150 | - | ns typ | Test Circuit 4 |
| topen | All | 5 | 5 | ns typ | $\mathrm{ton}^{-t_{\text {OFF }} ;}$; Test Circuit 4 |
| Output Settling Time to 0.1\% | All | 180 | - | ns typ | $\mathrm{V}_{\text {IN }}=3 \mathrm{~V}$ to 0V; Test Circuit 4 |
| OFF Isolation | All | 72 | - | dB typ | $\begin{aligned} & \mathrm{V}_{\mathrm{s}}=3 \mathrm{~V} \mathrm{rms}, \mathrm{f}=100 \mathrm{kHz}, \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega ; \\ & \mathrm{C}_{\mathrm{L}}=10 \mathrm{pF} ; \text { Test Circuit } 5 \end{aligned}$ |
| Channel-to-Channel Crosstalk | All | 86 | - | dB typ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=3 \mathrm{~V} \mathrm{rms}, \mathrm{f}=100 \mathrm{kHz}, \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega ; \\ & \mathrm{C}_{\mathrm{L}}=10 \mathrm{pF} ; \text { Test Circuit } 6 \end{aligned}$ |
| Qinj, Charge Injection | All | 10 | - | pCtyp | $\mathbf{R}_{\mathbf{S}}=0 \mathbf{\Omega}, \mathrm{~V}_{\mathbf{S}}=0 \mathrm{~V}$; Test Circuit 7 |
| $\mathrm{C}_{5}$ (OFF) | All | 10 | - | pF typ |  |
| $\mathrm{C}_{\mathrm{D}}$ (OFF) | All | 10 | - | pF typ |  |
| $\mathrm{C}_{\mathrm{D}}, \mathrm{C}_{\mathrm{s}}(\mathrm{ON})$ | All | 30 | - | pFtyp |  |
| $\mathrm{C}_{\text {DS }}$ (OFF) | All | 0.5 | - | pF typ |  |
| POWER SUPPLY |  |  |  |  |  |
| $\mathrm{I}_{\mathrm{DD}}$ | All | 10 | 10 | mA max |  |
| Power Dissipation | All | 150 | 150 | $\mathrm{mW}^{\text {max }}$ | $\mathrm{V}_{\mathrm{DD}}=+15 \mathrm{~V}$ |

## NOTE

${ }^{1}$ The leakage specifications degrade marginally (typically $\ln A$ at $25^{\circ} \mathrm{C}$ ) with $\mathrm{V}_{\mathrm{D}}\left(\mathrm{V}_{\mathbf{S}}\right)=\mathrm{V}_{\mathbf{s s}}$.
Specifications subject to change without notice.


Power Dissipation (Any Package)

| Up to $+75^{\circ} \mathrm{C}$. . . . . . . . . . . . . . . . . . 470 mWDerates above $+75^{\circ} \mathrm{C}$ by . . . . . . . . . . . . $6 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ |  |
| :---: | :---: |
|  |  |
| Operating Temperature |  |
| Commerical (J, K Version) | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Industrial (A, B Version) | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Extended (S, T Version) | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Lead Temperature (Soldering | $+300^{\circ} \mathrm{C}$ |

NOTES
${ }^{1}$ If $V_{S S}$ is open circuited with $V_{\text {DD }}$ and $G N D$ applied, the $V_{S S}$ pin will be pulled positive, exceeding the Absolute Maximum Ratings. If this possibility exists, a Schottky diode from $V_{\text {ss }}$ to GND (cathode end to GND) ensures that the Absolute Maximum Ratings will be observed.
${ }^{2}$ Overvoltage at IN, S or D, will be clamped by diodes. Current should be limited to the maximum rating above.
*COMMENT: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## CAUTION:

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are inserted.


## PIN CONFIGURATIONS



FEATURES
44V Supply Maximum Rating
$\pm 15 \mathrm{~V}$ Analog Signal Range
Low RoN ( $115 \Omega$ max)
Low Leakage (0.5nA typ)
Break Before Make Switching
Single Supply Operation Possible
Extended Plastic Temperature Range
$\left(-40^{\circ} \mathrm{C}\right.$ to $\left.+85^{\circ} \mathrm{C}\right)$
TTLCMOS Compatible
Available in 16-Lead DIP/SOIC and
20-Lead PLCC Packages
Superior Second Source:
ADG211A Replaces DG211
ADG212A Replaces DG212

## GENERAL DESCRIPTION

The ADG211A and ADG212A are monolithic CMOS devices comprising four independently selectable switches. They are designed on an enhanced LC $^{2}$ MOS process which gives an increased signal handling capability of $\pm 15 \mathrm{~V}$. These switches also feature high switching speeds and low $\mathrm{R}_{\mathrm{ON}}$.
The ADG211A and ADG212A consist of four SPST switches. They differ only in that the digital control logic is inverted. In multiplexer applications, all switches exhibit break-before-make switching action when driven simultaneously. Inherent in the design is low charge injection for minimum transients when switching the digital inputs.


## PRODUCT HIGHLIGHTS

1. Extended Signal Range:

These switches are fabricated on an enhanced LC $^{2}$ MOS process, resulting in high breakdown and an increased analog signal range of $\pm 15 \mathrm{~V}$.
2. Single Supply Operation:

For applications where the analog signal is unipolar ( 0 V to 15 V ), the switches can be operated from a single +15 V supply.
3. Low Leakage:

Leakage currents in the range of 500 pA make these switches suitable for high precision circuits. The added feature of Break before Make allows for multiple outputs to be tied together for multiplexer applications while keeping leakage errors to a minimum.

| ADG211A | ADG212A | SWITCH <br> IN |
| :--- | :--- | :--- |
| 0 | 1 | CONDITION |
| 1 | 0 | ON |

Table I. Truth Table

ADG211A/ADG212A
$\left(\mathrm{V}_{\mathrm{DD}}=+15 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=-15 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=5 \mathrm{~V}\right.$, unless otherwise noted.)

|  | ADG211AKN ADG212AKN |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
| Parameter | $25^{\circ} \mathrm{C}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Units | Test Conditions |
| ANALOG SWITCH <br> Analog Signal Range $\mathrm{R}_{\mathrm{ON}}$ <br> $\mathrm{R}_{\mathrm{ON}}$ vs. $\mathrm{V}_{\mathrm{D}}\left(\mathrm{V}_{\mathrm{S}}\right)$ <br> $\mathrm{R}_{\mathrm{ON}}$ Drift <br> $\mathrm{R}_{\mathrm{ON}}$ Match | $\begin{aligned} & \pm 15 \\ & 115 \\ & \\ & 20 \\ & 0.5 \\ & 5 \end{aligned}$ | $\begin{aligned} & \pm 15 \\ & 175 \end{aligned}$ | Volts <br> $\Omega_{\text {max }}$ <br> \% typ <br> \%/ ${ }^{\circ} \mathrm{C}$ typ <br> \% typ | $-10 \mathrm{~V} \leqslant \mathrm{~V}_{\mathrm{S}} \leqslant+10 \mathrm{~V}, \mathrm{I}_{\mathrm{DS}}=1 \mathrm{~mA}$ <br> Test Circuit 1 $\mathrm{V}_{\mathrm{S}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{DS}}=1 \mathrm{~mA}$ |
| $\mathrm{I}_{\mathrm{S}}(\mathrm{OFF})$ <br> OFF Input Leakage $\mathrm{I}_{\mathrm{D}}(\mathrm{OFF})$ <br> OFF Output Leakage $\mathrm{I}_{\mathrm{D}}(\mathrm{ON})$ <br> ON Channel Leakage | $\begin{aligned} & 0.5 \\ & 5 \\ & 0.5 \\ & 5 \\ & 0.5 \\ & 5 \end{aligned}$ | $\begin{aligned} & 100 \\ & 100 \\ & 200 \end{aligned}$ | nA typ nA max nA typ nA max nA typ nA max | $\mathrm{V}_{\mathrm{D}}= \pm 14 \mathrm{~V} ; \mathrm{V}_{\mathrm{S}}=\mp 14 \mathrm{~V} ;$ Test Circuit 2 <br> $\mathrm{V}_{\mathrm{D}}= \pm 14 \mathrm{~V} ; \mathrm{V}_{\mathrm{S}}=\mp 14 \mathrm{~V}$; Test Circuit 2 <br> $\mathrm{V}_{\mathrm{D}}=\mathrm{V}_{\mathrm{S}}= \pm 14 \mathrm{~V}$; Test Circuit 3 |
| DIGITALCONTROL <br> $V_{\text {INH }}$, Input High Voltage <br> $\mathrm{V}_{\text {INL }}$, Input Low Voltage <br> $\mathrm{I}_{\text {INL }}$ or $\mathrm{I}_{\text {INH }}$ <br> $\mathrm{C}_{\text {IN }}$, Digital Input Capacitance | 5 | $\begin{aligned} & 2.4 \\ & 0.8 \\ & 1 \end{aligned}$ | $V_{\text {min }}$ <br> $V$ max <br> $\mu \mathrm{A}$ max <br> pF typ | TTL Compatibility is Independent of $\mathrm{V}_{\mathrm{L}}$ |
| DYNAMICCHARACTERISTICS <br> topen ${ }^{1}$ <br> $\mathrm{tON}^{1}$ <br> $\mathrm{t}_{\mathrm{OFF}}{ }^{1}$ <br> OFF Isolation <br> Channel-to-Channel Crosstalk <br> $\mathrm{C}_{\mathrm{S}}$ (OFF) <br> $\mathrm{C}_{\mathrm{D}}$ (OFF) <br> $\mathrm{C}_{\mathrm{S}}, \mathrm{C}_{\mathrm{D}}$ (ON) <br> $\mathrm{Q}_{\text {INJ }}$, Charge Injection | 30 600 450 80 80 5 5 16 20 |  | ns typ ns max ns max dB typ <br> dB typ pF typ pF typ pF typ pCtyp | Test Circuit 4 <br> Test Circuit 5 <br> Test Circuit 5 $V_{S}=10 \mathrm{~V}(\mathrm{p}-\mathrm{p}) ; \mathrm{f}=100 \mathrm{kHz}$ <br> $\mathrm{R}_{\mathrm{L}}=75 \Omega$; Test Circuit 6 <br> Test Circuit 7 $\mathrm{R}_{\mathrm{S}}=0 \Omega ; \mathrm{C}_{\mathrm{L}}=1000 \mathrm{pF} ; \mathrm{V}_{\mathrm{S}}=0 \mathrm{~V}$ <br> Test Circuit 8 |
|  | $\begin{aligned} & 0.6 \\ & 1 \\ & 0.1 \\ & 0.2 \\ & 0.9 \end{aligned}$ |  | mA typ <br> $m A$ max <br> mA typ <br> $m A \max$ <br> $m A \max$ | Digital Inputs $=\mathrm{V}_{\text {INL }}$ or $\mathrm{V}_{\text {INH }}$ |

NOTE
${ }^{1}$ Sample tested at $25^{\circ} \mathrm{C}$ to ensure compliance.
Specifications subject to change without notice.

| ABSOLUTE MAXIMUM RATINGS* <br> ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise stated) | Digital Inputs ${ }^{1}$ <br> Voltage at IN .................. . $V_{V_{S s}-2 V}$ to |
| :---: | :---: |
| $\mathrm{V}_{\mathrm{DD}}$ to $\mathrm{V}_{\text {SS }}$. . . . . . . . . . . . . . . . . . . . . . . . 44 V | 20 mA , Whichever Occurs First |
| V ${ }_{\text {DD }}$ to GND . . . . . . . . . . . . . . . . . . . . . . . $25 V$ | Power Dissipation (Any Package) |
| $\mathrm{V}_{\text {Ss }}$ to GND . . . . . . . . . . . . . . . . . . . . . . . -25 V | Up to $+75^{\circ} \mathrm{C}$. . . . . . . . . . . . . . . . . . . . 470 mW |
| $\mathrm{V}_{\mathrm{L}}$ to GND . . . . . . . . . . . . . . . . . . . . $-0.3 \mathrm{~V}, 25 \mathrm{~V}$ | Derates above $+75^{\circ} \mathrm{C}$ by . . . . . . . . . . . . $6 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ |
| Analog Inputs ${ }^{1}$ | Operating Temperature . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Voltage at S, D . . . . . . . . . $\mathrm{V}_{\text {SS }}-0.3 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ | Storage Temperature Range . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Continuous Current, S or D . . . . . . . . . . . . 30 mA | Lead Temperature (Soldering 10sec) . . . . . . . . $+300^{\circ} \mathrm{C}$ |
| Pulsed Current S or D | NOTE |
| Ims Duration, 10\% Duty Cycle . . . . . . . . . 70 mA | ${ }^{1}$ Overvoltage at $I N, S$ or $D$ will be clamped by diodes. Current should be limited to the Maximum Rating above. |

*COMMENT: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Only one Absolute Maximum Rating may be applied at any one time.

## CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are removed.


## PIN CONFIGURATIONS



ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Option |
| :--- | :--- | :--- |
| ADG211AKN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | N-16 |
| ADG211AKR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | R-16A |
| ADG211AKP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | P-20A |
| ADG212AKN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | N-16 |
| ADG212AKR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | R-16A |
| ADG212AKP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | P-20A |

${ }^{\star} \mathrm{N}=$ Plastic DIP; $\mathrm{R}=0.15^{\prime \prime}$ Small Outline IC (SOIC); $\mathbf{P}=$ Plastic Leaded Chip Carrier (PLCC). For outline information see Package Information section.

The switches can comfortably operate anywhere in the 10 V to 15 V single or dual supply range, with only a slight degradation in performance. The following graphs show the relevant performance curves. The test circuits and test conditions are given in a following section, "Test Circuits."


Figure 1. Ron as a Function of $V_{D}\left(V_{S}\right)$ : Dual $\pm 15$ Supplies


Figure 3. Ron as a Function of $V_{D}\left(V_{S}\right)$ : Dual $\pm 10 \mathrm{~V}$ Supplies


Figure 5. Leakage Current as a Function of Temperature (Note: Leakage Current Reduces as the Supply Voltages Reduce)



Figure 4. Ron as a Function of $V_{D}\left(V_{S}\right)$ : Single +10 V Supply


Figure 6. Trigger Levels vs. Power Supply Voltage, Dual or Single Supply Voltage

FEATURES
44 V Supply Maximum Ratings
$V_{s s}$ to $V_{D D}$ Analog Signal Range
Low On Resistance ( $80 \Omega$ max)
Low Power
Fast Switching
$\mathrm{t}_{\text {ON }}<160$ ns
$\mathbf{t}_{\text {off }}<150$ ns
Break Before Make Switching Action
Plug-In Upgrade for
DG506A/ADG506A, DG507A/ADG507A, DG526/ADG526A
ADG406/ADG407 are Plug-In Replacements for DG406/DG407

## APPLICATIONS

## Audio and Video Routing

Automatic Test Equipment
Data Acquisition Systems
Battery Powered Systems
Sample Hold Systems
Communication Systems
Avionics

## GENERAL DESCRIPTION

The ADG406, ADG407 and ADG426 are monolithic CMOS analog multiplexers. The ADG406 and ADG426 switch one of sixteen inputs to a common output as determined by the 4 -bit binary address lines A0, A1, A2 and A3. The ADG426 has onchip address and control latches that facilitate microprocessor interfacing. The ADG407 switches one of eight differential inputs to a common differential output as determined by the 3bit binary address lines A0, A1 and A2. An EN input on all devices is used to enable or disable the device. When disabled, all channels are switched OFF.

The ADG406/ADG407/ADG426 are designed on an enhanced $L^{2}$ MOS process that provides low power dissipation yet gives high switching speed and low on resistance. These features make the parts suitable for high speed data acquisition systems and audio signal switching. Low power dissipation makes the parts suitable for battery powered systems. Each channel conducts equally well in both directions when ON and has an input signal range which extends to the supplies. In the OFF condition, signal levels up to the supplies are blocked. All channels exhibit break before make switching action preventing momentary shorting when switching channels. Inherent in the design is low charge injection for minimum transients when switching the digital inputs.

## FUNCTIONAL BLOCK DIAGRAMS



A0 A1 A2 A3 EN


A0 A1 A2 EN


## PRODUCT HIGHLIGHTS

1. Extended Signal Range

The ADG406/ADG407/ADG426 are fabricated on an enhanced LC ${ }^{2}$ MOS process giving an increased signal range which extends to the supply rails
2. Low Power Dissipation
3. Low $\mathrm{R}_{\mathrm{ON}}$
4. Single/Dual Supply Operation
5. Single Supply Operation

For applications where the analog signal is unipolar, the ADG406/ADG407/ADG426 can be operated from a single rail power supply. The parts are fully specified with a single +12 V power supply and will remain functional with single supplies as low as +5 V .

[^92]DUAL SUPPLY ( $\mathrm{V}_{00}=+15 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{\mathrm{SS}}=-15 \mathrm{~V} \pm 10 \%, \mathrm{GND}=0 \mathrm{~V}$, unless otherwise noted)


## Notes

[^93]SINGLE SUPPLY $\left(\mathrm{V}_{00}=+12 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{\mathrm{s}}=0 \mathrm{~V}, \mathrm{GND}=0 \mathrm{~V}\right.$, unless otherwise noted)


## NOTES

[^94]

ORDERING GUIDE

| Model | Temperature Range | Package Option |
| :--- | :--- | :--- |
| ADG406BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-28$ |
| ADG406BP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{P}-28 \mathrm{~A}$ |
| ADG407BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-28$ |
| ADG407BP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{P}-28 \mathrm{~A}$ |
| ADG426BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-28$ |
| ADG426BRS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{RS}-28$ |

* $N=$ Plastic DIP, $P=$ Plastic Leaded Chip Carrier (PLCC), RS = Shrink Small Outline Package (SSOP). For outline information see Package Information section.


## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although these devices feature proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

Table I. Truth Table (ADG406)

| A3 | A2 | A1 | A0 | EN | ON SWITCH |
| :--- | :--- | :--- | :--- | :--- | :--- |
| X | X | X | X | 0 | NONE |
| 0 | 0 | 0 | 0 | 1 | 1 |
| 0 | 0 | 0 | 1 | 1 | 2 |
| 0 | 0 | 1 | 0 | 1 | 3 |
| 0 | 0 | 1 | 1 | 1 | 4 |
| 0 | 1 | 0 | 0 | 1 | 5 |
| 0 | 1 | 0 | 1 | 1 | 6 |
| 0 | 1 | 1 | 0 | 1 | 7 |
| 0 | 1 | 1 | 1 | 1 | 8 |
| 1 | 0 | 0 | 0 | 1 | 9 |
| 1 | 0 | 0 | 1 | 1 | 10 |
| 1 | 0 | 1 | 0 | 1 | 11 |
| 1 | 0 | 1 | 1 | 1 | 12 |
| 1 | 1 | 0 | 0 | 1 | 13 |
| 1 | 1 | 0 | 1 | 1 | 14 |
| 1 | 1 | 1 | 0 | 1 | 15 |
| 1 | 1 | 1 | 1 | 1 | 16 |

Table II. Truth Table (ADG407)

| A2 | A1 | A0 | EN | ON SWITCH PAIR |
| :--- | :--- | :--- | :--- | :--- |
| $\mathbf{X}$ | $\mathbf{X}$ | $\mathbf{X}$ | 0 | NONE |
| 0 | 0 | 0 | 1 | 1 |
| 0 | 0 | 1 | 1 | 2 |
| 0 | 1 | 0 | 1 | 3 |
| 0 | 1 | 1 | 1 | 4 |
| 1 | 0 | 0 | 1 | 5 |
| 1 | 0 | 1 | 1 | 6 |
| 1 | 1 | 0 | 1 | 7 |
| 1 | 1 | 1 | 1 | 8 |

Table III. Truth Table (ADG426)

| $\mathbf{A 3}$ | $\mathbf{A 2}$ | $\mathbf{A 1}$ | $\mathbf{A 0}$ | $\mathbf{E N}$ | $\overline{\mathbf{W R}}$ | $\overline{\mathbf{R S}}$ | $\mathbf{O N}$ SWITCH |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| $\mathbf{X}$ | $\mathbf{X}$ | $\mathbf{X}$ | $\mathbf{X}$ | $\mathbf{X}$ | $\mathbf{5}$ | 1 | Retains Previous <br> Switch Condition |
| $\mathbf{X}$ | $\mathbf{X}$ | $\mathbf{X}$ | $\mathbf{X}$ | $\mathbf{X}$ | $\mathbf{X}$ | 0 | NONE (Address <br> and Enable |
|  |  |  |  |  |  |  | Latches Cleared) |
| $\mathbf{X}$ | $\mathbf{X}$ | $\mathbf{X}$ | $\mathbf{X}$ | 0 | 0 | 1 | NONE |
| 0 | 0 | 0 | 0 | 1 | 0 | 1 | 1 |
| 0 | 0 | 0 | 1 | 1 | 0 | 1 | 2 |
| 0 | 0 | 1 | 0 | 1 | 0 | 1 | 3 |
| 0 | 0 | 1 | 1 | 1 | 0 | 1 | 4 |
| 0 | 1 | 0 | 0 | 1 | 0 | 1 | 5 |
| 0 | 1 | 0 | 1 | 1 | 0 | 1 | 6 |
| 0 | 1 | 1 | 0 | 1 | 0 | 1 | 7 |
| 0 | 1 | 1 | 1 | 1 | 0 | 1 | 8 |
| 1 | 0 | 0 | 0 | 1 | 0 | 1 | 9 |
| 1 | 0 | 0 | 1 | 1 | 0 | 1 | 10 |
| 1 | 0 | 1 | 0 | 1 | 0 | 1 | 11 |
| 1 | 0 | 1 | 1 | 1 | 0 | 1 | 12 |
| 1 | 1 | 0 | 0 | 1 | 0 | 1 | 13 |
| 1 | 1 | 0 | 1 | 1 | 0 | 1 | 14 |
| 1 | 1 | 1 | 0 | 1 | 0 | 1 | 15 |
| 1 | 1 | 1 | 1 | 1 | 0 | 1 | 16 |

PIN CONFIGURATIONS
DIP
PLCC



PIN CONFIGURATION DIP/SSOP


## TIMING DIAGRAMS (ADG426)



Figure 1.
Figure 1 shows the timing sequence for latching the switch address and enable inputs. The latches are level sensitive; therefore, while $\overline{\mathrm{WR}}$ is held low, the latches are transparent and the switches respond to the address and enable inputs. This input data is latched on the rising edge of $\overline{\mathrm{WR}}$.


Figure 2.
Figure 2 shows the Reset Pulse Width, $\mathrm{t}_{\mathrm{Rs}}$, and the Reset Turn Off Time, $\mathrm{t}_{\mathrm{OFF}}(\overline{\mathrm{RS}})$.
Note: All digital input signals rise and fall times are measured from $10 \%$ to $90 \%$ of $3 \mathrm{~V} . \mathrm{t}_{\mathrm{R}}=\mathrm{t}_{\mathrm{F}}=20 \mathrm{~ns}$.

## TERMINOLOGY

| $\mathrm{V}_{\mathrm{DD}}$ | Most positive power supply potential. |
| :---: | :---: |
| $\mathrm{V}_{\text {ss }}$ | Most negative power supply potential in dual supplies. In single supply applications, it may be connected to ground. |
| GND | Ground ( 0 V ) reference. |
| $\mathrm{R}_{\text {ON }}$ | Ohmic resistance between D and S . |
| $\mathrm{R}_{\mathrm{oN}}$ Match | Difference between the $R_{\mathrm{ON}}$ of any two channels. |
| $\mathrm{I}_{\text {S }}(\mathrm{OFF})$ | Source leakage current when the switch is off. |
| $\mathrm{I}_{\mathrm{D}}$ (OFF) | Drain leakage current when the switch is off. |
| $\mathrm{I}_{\mathrm{D}}, \mathrm{I}_{\mathrm{S}}(\mathrm{ON})$ | Channel leakage current when the switch is on. |
| $\mathrm{V}_{\mathrm{D}}\left(\mathrm{V}_{\mathrm{S}}\right)$ | Analog voltage on terminals D, S. |
| $\mathrm{C}_{\text {S }}$ (OFF) | Channel input capacitance for "OFF" condition. |
| $\mathrm{C}_{\mathrm{D}}$ (OFF) | Channel output capacitance for "OFF" condition. |
| $\mathrm{C}_{\mathrm{D}}, \mathrm{C}_{\text {S }}(\mathrm{ON})$ | "ON" switch capacitance. |
| $\mathrm{C}_{\text {IN }}$ | Digital input capacitance. |
| $\mathrm{t}_{\mathrm{ON}}(\mathrm{EN})$ | Delay time between the $50 \%$ and $90 \%$ points of the digital input and switch "ON" condition. |
| $\mathrm{t}_{\text {OFF }}(\mathrm{EN})$ | Delay time between the $50 \%$ and $90 \%$ points of the digital input and switch "OFF" condition. |
| $\mathrm{t}_{\text {TRANSITION }}$ | Delay time between the $50 \%$ and $90 \%$ points of the digital inputs and the switch "ON" condition when switching from one address state to another. |
| $\mathrm{t}_{\text {OPEN }}$ | "OFF" time measured between $80 \%$ points of both switches when switching from one address state to another. |
| $\mathrm{V}_{\text {INL }}$ | Maximum input voltage for logic " 0 ." |
| $\mathrm{V}_{\text {INH }}$ | Minimum input voltage for logic "1." |
| $\mathrm{I}_{\mathrm{INL}}\left(\mathrm{I}_{\text {INH }}\right)$ | Input current of the digital input. |
| Crosstalk | A measure of unwanted signal which is coupled through from one channel to another as a result of parasitic capacitance. |
| Off Isolation | A measure of unwanted signal coupling through an "OFF" channel. |
| Charge | A measure of the glitch impulse |
| Injection | transferred from the digital input to the analog output during switching. |
| $\mathrm{I}_{\mathrm{DD}}$ | Positive supply current. |
| $\mathrm{I}_{\text {SS }}$ | Negative supply current. | LC ${ }^{2}$ MOS $4 / 8$ Channel High Performance Analog Multiplexers

## ADG408/ADG409

## FEATURES

44 V Supply Maximum Ratings $\mathbf{V}_{\text {ss }}$ to $\mathbf{V}_{\text {DD }}$ Analog Signal Range
Low On Resistance ( $100 \Omega$ max)
Low Power ( $\mathrm{I}_{\text {supply }}<75 \mu \mathrm{~A}$ )
Fast Switching
Break-Before-Make Switching Action
Plug-in Replacement for DG408/DG409
APPLICATIONS
Audio and Video Routing
Automatic Test Equipment
Data Acquisition Systems
Battery Powered Systems
Sample and Hold Systems
Communication Systems

## GENERAL DESCRIPTION

The ADG408 and ADG409 are monolithic CMOS analog multiplexers comprising 8 single channels and four differential channels respectively. The ADG408 switches one of eight inputs to a common output as determined by the 3-bit binary address lines A0, A1 and A2. The ADG409 switches one of four differential inputs to a common differential output as determined by the 2-bit binary address lines A0 and A1. An EN input on both devices is used to enable or disable the device. When disabled, all channels are switched OFF.
The ADG408/ADG409 are designed on an enhanced LC $^{2}$ MOS process which provides low power dissipation yet gives high switching speed and low on resistance. Each channel conducts equally well in both directions when ON and has an input signal range which extends to the supplies. In the OFF condition, signal levels up to the supplies are blocked. All channels exhibit break before make switching action preventing momentary shorting when switching channels. Inherent in the design is low charge injection for minimum transients when switching the digital inputs.
The ADG408/ADG409 are improved replacements for the DG408/DG409 Analog Multiplexers.

FUNCTIONAL BLOCK DIAGRAMS


## PRODUCT HIGHLIGHTS

1. Extended Signal Range

The ADG408/ADG409 are fabricated on an enhanced $L^{2}$ MOS process giving an increased signal range that extends to the supply rails.
2. Low Power Dissipation
3. Low $\mathrm{R}_{\mathrm{ON}}$
4. Single Supply Operation

For applications where the analog signal is unipolar, the ADG408/ADG409 can be operated from a single rail power supply. The parts are fully specified with a single +12 V power supply and will remain functional with single supplies as low as +5 V .

DUAL SUPPLY ${ }^{1}\left(\mathrm{v}_{00}=+15 \mathrm{~V}, \mathrm{v}_{55}=-15 \mathrm{~V}, \mathrm{GNO}=0 \mathrm{~V}\right.$, unless othewise noted)

| Parameter | $\begin{gathered} \text { B Version } \\ +25^{\circ} \mathrm{C} \quad+80^{\circ} \mathrm{C} \text { to } \end{gathered}$ |  | $\begin{gathered} \text { T Version } \\ +25^{\circ} \mathrm{C} \quad-55^{\circ} \mathrm{C} \text { to } \\ +125^{\circ} \mathrm{C} \end{gathered}$ |  | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ANALOG SWITCH Analog Signal Range $\mathrm{R}_{\mathrm{ON}}$ $\Delta \mathrm{R}_{\mathrm{ON}}$ | $\begin{aligned} & 40 \\ & 100 \\ & 15 \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{ss}} \text { to } \mathrm{V}_{\mathrm{DD}} \\ & 125 \end{aligned}$ | $\begin{aligned} & 40 \\ & 100 \\ & 15 \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{Ss}} \text { to } \mathrm{V}_{\mathrm{DD}} \\ & 125 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \Omega \operatorname{typ} \\ & \Omega \max \\ & \Omega \max \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{D}}= \pm 10 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=-10 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{D}}=+10 \mathrm{~V},-10 \mathrm{~V} \end{aligned}$ |
| LEAKAGE CURRENTS <br> Source OFF Leakage $\mathrm{I}_{\mathrm{s}}$ (OFF) <br> Drain OFF Leakage $I_{D}$ (OFF) <br> ADG408 <br> ADG409 <br> Channel ON Leakage $\mathrm{I}_{\mathrm{D}}, \mathrm{I}_{\mathrm{S}}(\mathrm{ON})$ <br> ADG408 <br> ADG409 | $\begin{aligned} & \pm 0.5 \\ & \\ & \pm 1 \\ & \pm 1 \\ & \pm 1 \\ & \pm 1 \end{aligned}$ | $\begin{aligned} & \pm 50 \\ & \pm 100 \\ & \pm 50 \\ & \pm 100 \\ & \pm 50 \end{aligned}$ | $\begin{aligned} & \pm 0.5 \\ & \pm 1 \\ & \pm 1 \\ & \pm 1 \\ & \pm 1 \end{aligned}$ | $\begin{aligned} & \pm 50 \\ & \pm 100 \\ & \pm 50 \\ & \pm 100 \\ & \pm 50 \end{aligned}$ | $n A \max$ <br> nA max $n A \max$ <br> nA max nA max | $\begin{aligned} & \mathrm{V}_{\mathrm{D}}= \pm 10 \mathrm{~V}, \mathrm{~V}_{\mathrm{s}}=\mp 10 \mathrm{~V} ; \\ & \text { Test Circuit } 2 \\ & \mathrm{~V}_{\mathrm{D}}= \pm 10 \mathrm{~V} ; \mathrm{V}_{\mathrm{s}}=\mp 10 \mathrm{~V} ; \\ & \text { Test Circuit } 3 \end{aligned}$ $\mathrm{V}_{\mathrm{s}}=\mathrm{V}_{\mathrm{D}}= \pm 10 \mathrm{~V} ;$ <br> Test Circuit 4 |
| DIGITAL INPUTS <br> Input High Voltage, $\mathrm{V}_{\text {INH }}$ Input Low Voltage, $\mathrm{V}_{\text {INL }}$ Input Current $\mathrm{I}_{\text {INL }}$ or $\mathrm{I}_{\text {INH }}$ <br> $\mathrm{C}_{\mathrm{IN}}$, Digital Input Capacitance | 8 | $\begin{aligned} & 2.4 \\ & 0.8 \\ & \pm 10 \end{aligned}$ | 8 | $\begin{aligned} & 2.4 \\ & 0.8 \\ & \pm 10 \end{aligned}$ | V min <br> V max <br> $\mu$ A max <br> pF typ | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=0 \text { or } \mathrm{V}_{\mathrm{DD}} \\ & \mathrm{f}=1 \mathrm{MHz} \end{aligned}$ |
| DYNAMIC CHARACTERISTICS ${ }^{2}$ <br> $\mathrm{t}_{\text {transition }}$ <br> topen <br> $\mathrm{t}_{\mathrm{ON}}$ (EN) <br> $\mathrm{t}_{\mathrm{OFF}}$ (EN) <br> Charge Injection <br> OFF Isolation <br> Channel-to-Channel Crosstalk <br> $\mathrm{C}_{\mathrm{s}}$ (OFF) <br> $\mathrm{C}_{\mathrm{D}}$ (OFF) <br> ADG408 <br> ADG409 <br> $\mathrm{C}_{\mathrm{D}}, \mathrm{C}_{\mathrm{S}}(\mathrm{ON})$ <br> ADG408 <br> ADG409 | $\begin{aligned} & 10 \\ & 85 \\ & 150 \\ & 20 \\ & -75 \\ & 85 \\ & 11 \\ & 11 \\ & 40 \\ & 20 \\ & 54 \\ & 34 \end{aligned}$ | $\begin{aligned} & 120 \\ & 250 \\ & 10 \\ & \\ & 125 \\ & 225 \\ & 65 \\ & 150 \end{aligned}$ | $\begin{aligned} & 10 \\ & 85 \\ & 150 \\ & 20 \\ & -75 \\ & -75 \\ & 85 \\ & 11 \\ & 40 \\ & 20 \\ & 54 \\ & 34 \end{aligned}$ | $\begin{aligned} & 120 \\ & 250 \\ & 10 \\ & 125 \\ & 225 \\ & 65 \\ & 150 \end{aligned}$ | ns typ <br> ns $\min$ <br> ns typ <br> ns max <br> ns typ <br> ns max <br> pC typ <br> dB typ <br> dB typ <br> pF typ <br> pF typ <br> pF typ <br> pF typ <br> pF typ |  |
| ```POWER REQUIREMENTS \(I_{D D}\) \(\mathrm{I}_{\mathrm{ss}}\) \(I_{D D}\)``` | $\begin{aligned} & 100 \\ & 200 \end{aligned}$ | $\begin{aligned} & 1 \\ & 5 \\ & 1 \\ & 5 \end{aligned}$ $500$ | $\begin{aligned} & 100 \\ & 200 \end{aligned}$ | $\begin{aligned} & 1 \\ & 5 \\ & 1 \\ & 5 \\ & 500 \end{aligned}$ | $\mu \mathrm{A}$ typ $\mu \mathrm{A}$ max $\mu \mathrm{A}$ typ $\mu \mathrm{A}$ max $\mu \mathrm{A}$ typ $\mu \mathrm{A}$ max | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{EN}}=0 \mathrm{~V}$ $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{EN}}=2.4 \mathrm{~V}$ |

NOTES
${ }^{1}$ Temperature ranges are as follows: B Versions: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; T Versions: $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
${ }^{2}$ Guaranteed by design, not subject to production test.
Specifications subject to change without notice.

SINGLE SUPPLY ${ }^{1}{ }_{V_{00}}=+12 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{GNO}=0 \mathrm{~V}$, uniess otherwise notedi)


## NOTES

${ }^{1}$ Temperature ranges are as follows: B Versions: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; T Versions: $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
${ }^{2}$ Guaranteed by design, not subject to production test.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

| ( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted) |  |
| :---: | :---: |
| $\mathrm{V}_{\text {DD }}$ to $\mathrm{V}_{\text {SS }}$ |  |
| $\mathrm{V}_{\text {DD }}$ to GND |  |
| $\mathrm{V}_{\text {ss }}$ to GND . . . . . . . . . . . . . . . . . . +0.3 V to - 25 V |  |
| Analog, Digital Inputs ${ }^{2} \ldots \mathrm{~V}_{\mathrm{ss}}-2 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}+2 \mathrm{~V}$ or 20 mA , Whichever Occurs First |  |
| Continuous Current, S or D | A |
| Peak Current, S or D |  |
| Operating Temperature Range |  |
| Industrial (B Version) | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Extended (T Version) | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Junction Temperature | $+150^{\circ} \mathrm{C}$ |
| Cerdip Package, Power Dissipation . . . . . . . . . . . . . 900 mW |  |
| $\theta_{\mathrm{JA}}$, Thermal Impedance . . . . . . . . . . . . . . . . . . 76º <br> Lead Temperature, Soldering ( 10 sec ) . . . . . . . . . . $+300^{\circ} \mathrm{C}$ |  |
|  |  |
| Plastic Package, Power Dissipation . . . . . . . . . . . 470 mW |  |
| $\theta_{\text {JA }}$, Thermal Impedance . . . . . . . . . . . . . . . . . . $117^{\circ} \mathrm{C} / \mathrm{W}$ <br> Lead Temperature, Soldering ( 10 sec ) . . . . . . . . . . $+260^{\circ} \mathrm{C}$ |  |
|  |  |
| SOIC Package, Power Dissipation . . . . . . . . . . . . . 600 mW |  |
| $\theta_{\mathrm{JA}}$, Thermal Impedance . . . . . . . . . . . . . . . . . . $77^{\circ} \mathrm{C} / \mathrm{W}$ <br> Lead Temperature, Soldering |  |
|  |  |
| Vapor Phase (60 sec) |  |
| Infrared (15 sec) | $+220^{\circ} \mathrm{C}$ |

## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Only one absolute maximum rating may be applied at any one time. ${ }^{2}$ Overvoltages at A, EN, S or D will be clamped by internal diodes. Current should be limited to the maximum ratings given.

ORDERING INFORMATION

| Model $^{\mathbf{1}}$ | Temperature Range | Package Option |
| :--- | :--- | :--- |
| ADG408BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| ADG408BR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16 \mathrm{~A}$ |
| ADG408TQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| ADG409BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| ADG409BR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16 \mathrm{~A}$ |
| ADG409TQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |

## NOTES

${ }^{1}$ To order MIL-STD-883, Class B processed parts, add /883B to T grade part numbers.
${ }^{2} \mathrm{~N}=$ Plastic $\cdot$ DIP; $\mathrm{R}=0.15^{\prime \prime}$ Small Outline IC (SOIC); $\mathrm{Q}=$ Cerdip. For outline information see Package Information section.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although these devices feature proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

PIN CONFIGURATIONS (DIP/SOIC)


ADG408 Truth Table

| A2 | A1 | A0 | EN | ON <br> SWITCH |
| :--- | :--- | :--- | :--- | :--- |
| $\mathbf{X}$ | $\mathbf{X}$ | $\mathbf{X}$ | 0 | NONE |
| 0 | 0 | 0 | 1 | 1 |
| 0 | 0 | 1 | 1 | 2 |
| 0 | 1 | 0 | 1 | 3 |
| 0 | 1 | 1 | 1 | 4 |
| 1 | 0 | 0 | 1 | 5 |
| 1 | 0 | 1 | 1 | 6 |
| 1 | 1 | 0 | 1 | 7 |
| 1 | 1 | 1 | 1 | 8 |

ADG409 Truth Table

| A1 | A0 | EN | ON SWITCH <br> PAIR |
| :--- | :--- | :--- | :--- |
| $\mathbf{X}$ | $\mathbf{X}$ | 0 | NONE |
| 0 | 0 | 1 | 1 |
| 0 | 1 | 1 | 2 |
| 1 | 0 | 1 | 3 |
| 1 | 1 | 1 | 4 |

## TERMINOLOGY

| $\mathrm{V}_{\text {DD }}$ | Most positive power supply potential. |
| :---: | :---: |
| $\mathrm{V}_{\text {SS }}$ | Most negative power supply potential in dual supplies. In single supply applications, it may be connected to ground. |
| GND | Ground ( 0 V ) reference. |
| $\mathrm{R}_{\text {ON }}$ | Ohmic resistance between D and S . |
| $\Delta \mathrm{R}_{\mathrm{ON}}$ | Difference between the $\mathrm{R}_{\mathrm{ON}}$ of any two channels. |
| $\mathrm{I}_{\mathrm{S}}$ (OFF) | Source leakage current when the switch is off. |
| $\mathrm{I}_{\mathrm{D}}$ (OFF) | Drain leakage current when the switch is off. |
| $\mathrm{I}_{\mathrm{D}}, \mathrm{I}_{\mathrm{S}}(\mathrm{ON})$ | Channel leakage current when the switch is on. |
| $\mathrm{V}_{\mathrm{D}}\left(\mathrm{V}_{\mathrm{S}}\right)$ | Analog voltage on terminals $\mathrm{D}, \mathrm{S}$. |
| $\mathrm{C}_{\mathrm{S}}$ (OFF) | Channel input capacitance for "OFF" condition. |
| $\mathrm{C}_{\mathrm{D}}$ (OFF) | Channel output capacitance for "OFF" condition. |
| $\mathrm{C}_{\mathrm{D}}, \mathrm{C}_{\mathrm{S}}(\mathrm{ON})$ | "ON" switch capacitance. |
| $\mathrm{C}_{\text {IN }}$ | Digital input capacitance. |
| $\mathrm{t}_{\mathrm{ON}}(\mathrm{EN})$ | Delay time between the $50 \%$ and $90 \%$ points of the digital input and switch "ON" condition. |
| $\mathrm{t}_{\text {OFF }}$ (EN) | Delay time between the $50 \%$ and $90 \%$ points of the digital input and switch "OFF" condition. |
| $\mathrm{t}_{\text {TRANSITION }}$ | Delay time between the $50 \%$ and $90 \%$ points of the digital inputs and the switch "ON" condition when switching from one address state to another. |
| $\mathrm{t}_{\text {OPEN }}$ | "OFF" time measured between the $80 \%$ points of both switches when switching from one address state to another. |
| $\mathrm{V}_{\text {INL }}$ | Maximum input voltage for logic "0." |
| $\mathrm{V}_{\text {INH }}$ | Minimum input voltage for logic " 1. " |
| $\mathrm{I}_{\text {INL }}\left(\mathrm{I}_{\mathrm{INH}}\right)$ | Input current of the digital input. |
| Crosstalk | A measure of unwanted signal which is coupled through from one channel to another as a result of parasitic capacitance. |
| Off Isolation | A measure of unwanted signal coupling through an "OFF" channel. |
| Charge Injection | A measure of the glitch impulse transferred from the digital input to the analog output during switching. |
| $\mathrm{I}_{\text {DD }}$ | Positive supply current. |
| $\mathrm{I}_{\text {ss }}$ | Negative supply current. |

## Typical Performance Characteristics



Figure 1. $R_{\mathrm{ON}}$ as a Function of $V_{D}\left(V_{S}\right)$ : Dual Supply Voltage


Figure 2. R $R_{O N}$ as a Function of $V_{D}\left(V_{S}\right)$ for Different Temperatures


Figure 3. Leakage Currents as a Function of $V_{D}\left(V_{s}\right)$


Figure 4. $R_{O N}$ as a Function of $V_{D}\left(V_{S}\right)$ : Single Supply Voltage


Figure 5. $R_{O N}$ as a Function of $V_{D}\left(V_{S}\right)$ for Different Temperatures


Figure 6. Leakage Currents as a Function of $V_{D}\left(V_{S}\right)$

## ADG408/ADG409



Figure 7. Switching Time vs. VIN (Bipolar Supply)


Figure 8. Switching Time vs. Single Supply


Figure 9. Positive Supply Current vs. Switching Frequency


Figure 10. Switching Time vs. $V_{I N}$ (Single Supply)


Figure 11. Switching Time vs. Bipolar Supply


Figure 12. Negative Supply Current vs. Switching Frequency


Figure 13. Off Isolation vs. Frequency


Figure 14. Crosstalk vs. Frequency

## FEATURES

44 V Supply Maximum Ratings $\pm 15$ V Analog Signal Range<br>Low On Resistance ( $<\mathbf{3 5} \boldsymbol{\Omega}$ )<br>Ultralow Power Dissipation ( $35 \mu \mathrm{~W}$ )<br>Fast Switching Times<br>$t_{\text {oN }}<175 \mathrm{~ns}$<br>$t_{\text {OFF }}<145$ ns<br>Latch-up Proof<br>TTL/CMOS Compatible<br>Plug-in Replacement for DG411/DG412/DG413

## APPLICATIONS

## Audio and Video Switching

Automatic Test Equipment
Precision Data Acquisition
Battery Powered Systems
Sample Hold Systems
Communication Systems

## GENERAL DESCRIPTION

The ADG411, ADG412 and ADG413 are monolithic CMOS devices comprising four independently selectable switches. They are designed on an enhanced LC $^{2}$ MOS, trench isolated process which provides low power dissipation yet gives high switching speed and low on resistance. Trench isolation gives all the benefits of dielectric isolation and ensures no latch up even under extreme overvoltage conditions.
The on resistance profile is very flat over the full analog input range ensuring excellent linearity and low distortion when switching audio signals. Fast switching speed coupled with high signal bandwidth also make the parts suitable for video signal switching. CMOS construction ensures ultralow power dissipation making the parts ideally suited for portable and battery powered instruments.
The ADG411, ADG412 and ADG413 contain four independent SPST switches. The ADG411 and ADG412 differ only in that the digital control logic is inverted. The ADG411 switches are turned on with a logic low on the appropriate control input, while a logic high is required for the ADG412. The ADG413 has two switches with digital control logic similar to that of the ADG411 while the logic is inverted on the other two switches.
Each switch conducts equally well in both directions when ON and has an input signal range which extends to the supplies. In the OFF condition, signal levels up to the supplies are blocked. All switches exhibit break before make switching action for use in multiplexer applications. Inherent in the design is low charge injection for minimum transients when switching the digital inputs.

FUNCTIONAL BLOCK DIAGRAMS



SWITCHES SHOWN FOR A LOGIC " 1 " INPUT

## PRODUCT HIGHLIGHTS

1. Extended Signal Range

The ADG411, ADG412 and ADG413 are fabricated on an enhanced LC $^{2}$ MOS, trench isolated process giving an increased signal range which extends fully to the supply rails.
2. Ultralow Power Dissipation
3. Low $\mathrm{R}_{\mathrm{ON}}$
4. Trench Isolation Guards Against Latch-up A dielectric trench separates the $\mathbf{P}$ and N channel transistors thereby preventing latch-up even under severe overvoltage conditions.
5. Break Before Make Switching This prevents channel shorting when the switches are configured as a multiplexer.
6. Single Supply Operation

For applications where the analog signal is unipolar, the ADG411, ADG412 and ADG413 can be operated from a single rail power supply. The parts are fully specified with a single +12 V power supply and will remain functional with single supplies as low as +5 V .

Dual Supply $\left(\mathrm{v}_{00}=+15 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{\mathrm{ss}}=-15 \mathrm{v} \pm 10 \%, \mathrm{~V}_{\mathrm{L}}=+5 \mathrm{~V} \pm 10 \%, 6 \mathrm{NO}=0 \mathrm{~V}\right.$, unless otherwise noted)

| Parameter | $$ |  | $$ |  | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ANALOG SWITCH Analog Signal Range $\mathrm{R}_{\mathrm{ON}}$ | $\begin{aligned} & 25 \\ & 35 \end{aligned}$ | $\begin{aligned} & V_{D D} \text { to } V_{S S} \\ & 45 \end{aligned}$ | $\begin{aligned} & 25 \\ & 35 \end{aligned}$ | $\begin{aligned} & V_{D D} \text { to } V_{S S} \\ & 45 \end{aligned}$ | V <br> $\Omega$ typ <br> $\Omega$ max | $\begin{aligned} & \mathrm{V}_{\mathrm{D}}= \pm 8.5 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=-10 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{DD}}=+13.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{Ss}}=-13.5 \mathrm{~V} \end{aligned}$ |
| LEAKAGE CURRENTS <br> Source OFF Leakage $I_{S}$ (OFF) <br> Drain OFF Leakage $I_{D}$ (OFF) <br> Channel ON Leakage $I_{D}, I_{S}(O N)$ | $\begin{aligned} & \pm 0.1 \\ & \pm 0.25 \\ & \pm 0.1 \\ & \pm 0.25 \\ & \pm 0.1 \\ & \pm 0.4 \end{aligned}$ | $\begin{aligned} & \pm 20 \\ & \pm 20 \\ & \pm 40 \end{aligned}$ | $\begin{aligned} & \pm 0.1 \\ & \pm 0.25 \\ & \pm 0.1 \\ & \pm 0.25 \\ & \pm 0.1 \\ & \pm 0.4 \end{aligned}$ | $\begin{aligned} & \pm 20 \\ & \pm 20 \\ & \pm 40 \end{aligned}$ | nA typ nA max nA typ nA max nA typ nA max | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=+16.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{ss}}=-16.5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{D}}= \pm 15.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{s}}=\mp 15.5 \mathrm{~V} ; \end{aligned}$ <br> Test Circuit 2 $\mathrm{V}_{\mathrm{D}}= \pm 15.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{s}}=\mp 15.5 \mathrm{~V} ;$ <br> Test Circuit 2 $\mathrm{V}_{\mathrm{D}}=\mathrm{V}_{\mathrm{s}}= \pm 15.5 \mathrm{~V}$ <br> Test Circuit 3 |
| DIGITAL INPUTS <br> Input High Voltage, $\mathrm{V}_{\text {INH }}$ Input Low Voltage, $\mathrm{V}_{\text {INL }}$ Input Current $\mathrm{I}_{\text {INL }}$ or $\mathrm{I}_{\text {INH }}$ | 0.005 | 2.4 <br> 0.8 $\pm 0.5$ | $0.005$ | 2.4 <br> 0.8 $\pm 0.5$ | V min <br> V max <br> $\mu \mathrm{A}$ typ <br> $\mu \mathrm{A}$ max | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {INL }}$ or $\mathrm{V}_{\text {INH }}$ |
| DYNAMIC CHARACTERISTICS ${ }^{2}$ <br> $\mathrm{t}_{\mathrm{ON}}$ <br> $\mathrm{t}_{\mathrm{OFF}}$ <br> Break-Before-Make Time Delay, $\mathrm{t}_{\mathrm{D}}$ (ADG413 Only) <br> Charge Injection <br> OFF Isolation <br> Channel-to-Channel Crosstalk <br> $\mathrm{C}_{\mathrm{s}}$ (OFF) <br> $\mathrm{C}_{\mathrm{D}}$ (OFF) <br> $C_{D}, C_{s}(O N)$ | 110 100 25 5 68 85 9 9 35 | 175 145 | $\begin{aligned} & 110 \\ & 100 \\ & 25 \\ & 5 \\ & 68 \\ & 85 \\ & 9 \\ & 9 \\ & 35 \end{aligned}$ | 175 145 | $\begin{aligned} & \text { ns typ } \\ & \text { ns max } \\ & \text { ns typ } \\ & \text { ns max } \\ & \text { ns typ } \\ & \text { pC typ } \\ & \text { dB typ } \\ & \text { dB typ } \\ & \text { pF typ } \\ & \text { pF typ } \\ & \mathrm{pF} \text { typ } \end{aligned}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF} ; \\ & \mathrm{V}_{\mathrm{S}}= \pm 10 \mathrm{~V} ; \mathrm{Test} \mathrm{Circuit} \\ & \mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF} ; \\ & \mathrm{V}_{\mathrm{S}}= \pm 10 \mathrm{~V} ; \mathrm{Test}^{2} \text { Circuit } 4 \\ & \mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF} ; \\ & \mathrm{V}_{\mathrm{S} 1}=\mathrm{V}_{\mathrm{S} 2}=+10 \mathrm{~V} ; \end{aligned}$ <br> Test Circuit 5 $\mathrm{V}_{\mathrm{S}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{S}}=0 \Omega, \mathrm{C}_{\mathrm{L}}=10 \mathrm{nF}$ <br> Test Circuit 6 $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{f}=1 \mathrm{MHz}$ <br> Test Circuit 7 $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{f}=1 \mathrm{MHz}$ <br> Test Circuit 8 $\mathrm{f}=1 \mathrm{MHz}$ $\mathrm{f}=1 \mathrm{MHz}$ $\mathrm{f}=1 \mathrm{MHz}$ |
| POWER REQUIREMENTS $\begin{aligned} & \mathrm{I}_{\mathrm{DD}} \\ & \mathrm{I}_{\mathrm{SS}} \\ & \mathrm{I}_{\mathrm{L}} \end{aligned}$ | $\begin{aligned} & 0.0001 \\ & 1 \\ & 0.0001 \\ & 1 \\ & 0.0001 \\ & 1 \end{aligned}$ | 5 5 5 | $\begin{array}{\|l} 0.0001 \\ 1 \\ 0.0001 \\ 1 \\ 0.0001 \\ 1 \\ \hline \end{array}$ | 5 5 5 | $\mu \mathrm{A}$ typ <br> $\mu \mathrm{A}$ max <br> $\mu \mathrm{A}$ typ <br> $\mu \mathrm{A}$ max <br> $\mu \mathrm{A}$ typ <br> $\mu \mathrm{A}$ max | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=+16.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=-16.5 \mathrm{~V} \\ & \text { Digital Inputs }=0 \mathrm{~V} \text { or } 5 \mathrm{~V} \end{aligned}$ |

## NOTES

${ }^{1}$ Temperature ranges are as follows: B Versions: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; T Versions: $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
${ }^{2}$ Guaranteed by design, not subject to production test.
Specifications subject to change without notice.

Single Supply $\left(V_{00}=+12 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{5 s}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=+5 \mathrm{~V} \pm 10 \%\right.$, $\mathrm{GNO}=0 \mathrm{~V}$, unless othemise noted)

| Parameter | $$ | $$ | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: |
| Analog Signal Range $\mathbf{R}_{\mathrm{ON}}$ | 40 0 V to $\mathrm{V}_{121)}$ <br> 80 100 | $\begin{array}{ll} \hline & 0 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{DD}} \\ 40 & 100 \\ 80 & \end{array}$ | $\mathrm{V}$ <br> $\Omega$ typ <br> $\Omega$ max | $\begin{aligned} & 0<\mathrm{V}_{\mathrm{D}}<8.5 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=-10 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{DD}}=+10.8 \mathrm{~V} \end{aligned}$ |
| LEAKAGE CURRENTS <br> Source OFF Leakage $I_{S}$ (OFF) <br> Drain OFF Leakage $I_{D}(O F F)$ <br> Channel ON Leakage $I_{D}, I_{S}(O N)$ | $\begin{array}{ll}  \pm 0.1 & \\ \pm 0.25 & \pm 20 \\ \pm 0.1 & \\ \pm 0.25 & \pm 20 \\ \pm 0.1 & \\ \pm 0.4 & \pm 40 \end{array}$ | $\begin{array}{ll}  \pm 0.1 & \\ \pm 0.25 & \pm 20 \\ \pm 0.1 & \\ \pm 0.25 & \pm 20 \\ \pm 0.1 & \\ \pm 0.4 & \pm 40 \end{array}$ | nA typ nA max nA typ nA max nA typ nA max | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=+13.2 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{D}}=12.2 / 1 \mathrm{~V}, \mathrm{~V}_{\mathrm{s}}=1 / 12.2 \mathrm{~V} ; \end{aligned}$ <br> Test Circuit 2 $\mathrm{V}_{\mathrm{D}}=12.2 / 1 \mathrm{~V}, \mathrm{v}_{\mathrm{s}}=1 / 12.2 \mathrm{~V} ;$ <br> Test Circuit 2 $\mathrm{V}_{\mathrm{D}}=\mathrm{V}_{\mathrm{s}}=+12.2 \mathrm{~V} /+1 \mathrm{~V} ;$ <br> Test Circuit 3 |
| DIGITAL INPUTS <br> Input High Voltage, $\mathrm{V}_{\text {INH }}$ Input Low Voltage, $\mathrm{V}_{\text {INI }}$. Input Current $\mathrm{I}_{\text {INL }}$ or $\mathrm{I}_{\text {INH }}$ | $\begin{array}{cc}  & 2.4 \\ & 0.8 \\ 0.005 & \\ & \pm 0.5 \end{array}$ | $\begin{array}{cc}  & 2.4 \\ & 0.8 \\ 0.005 & \\ & \pm 0.5 \end{array}$ | V min <br> V max <br> $\mu \mathrm{A}$ typ <br> $\mu \mathrm{A}$ max | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {INL }}$ or $\mathrm{V}_{\text {IN }}$ |
| DYNAMIC CHARACTERISTICS ${ }^{2}$ <br> $t_{\mathrm{ON}}$ <br> $t_{\text {OFF }}$ <br> Break-Before-Make Time Delay, $\mathrm{t}_{\mathrm{D}}$ (ADG413 Only) <br> Charge Injection <br> OFF Isolation <br> Channel-to-Channel Crosstalk <br> $\mathrm{C}_{\mathrm{S}}$ (OFF) <br> $\mathrm{C}_{\mathrm{D}}$ (OFF) <br> $\mathrm{C}_{\mathrm{D}}, \mathrm{C}_{\mathrm{S}}(\mathrm{ON})$ | 175  <br> 95 250 <br> 25 125 <br> 25  <br> 68  <br> 85  <br> 9  <br> 9  <br> 35  | 175   <br> 95 250  <br> 25   <br>    <br> 25   <br> 68   <br> 85   <br> 9   <br> 9   <br> 35   | $\begin{aligned} & \text { ns typ } \\ & \text { ns max } \\ & \text { ns typ } \\ & \text { ns max } \\ & \text { ns typ } \\ & \text { pC typ } \\ & \text { dB typ } \\ & \text { dB typ } \\ & \text { pF typ } \\ & \text { pF typ } \\ & \text { pF typ } \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF} ; \\ & \mathrm{V}_{\mathrm{S}}=+8 \mathrm{~V} ; \mathrm{Test}^{2} \text { Circuit } 4 \\ & \mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF} ; \\ & \mathrm{V}_{\mathrm{S}}=+8 \mathrm{~V} ; \mathrm{Test} \mathrm{Circuit} 4 \\ & \mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF} ; \\ & \mathrm{V}_{\mathrm{S} 1}=\mathrm{V}_{\mathrm{S} 2}=+10 \mathrm{~V} ; \end{aligned}$ <br> Test Circuit 5 $\mathrm{V}_{\mathrm{S}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{S}}=0 \Omega, \mathrm{C}_{\mathrm{L}}=10 \mathrm{nF}$ <br> Test Circuit 6 $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{f}=1 \mathrm{MHz}$ <br> Test Circuit 7 $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{f}=1 \mathrm{MHz}$ <br> Test Circuit 8 <br> $\mathrm{f}=1 \mathrm{MHz}$ <br> $\mathrm{f}=1 \mathrm{MHz}$ <br> $\mathrm{f}=1 \mathrm{MHz}$ |
| POWER REQUIREMENTS $\begin{aligned} & I_{D D} \\ & I_{L} \end{aligned}$ | $\begin{array}{ll} 0.0001 & \\ 1 & 5 \\ 0.0001 & \\ 1 & 5 \end{array}$ | $\begin{array}{ll} 0.0001 & \\ 1 & 5 \\ 0.0001 & \\ 1 & 5 \end{array}$ | $\mu \mathrm{A}$ typ $\mu \mathrm{A}$ max $\mu \mathrm{A}$ typ $\mu A \max$ | $\mathrm{V}_{\mathrm{DD}}=+13.2 \mathrm{~V}$ <br> Digital Inputs $=0 \mathrm{~V}$ or 5 V $\mathrm{V}_{\mathrm{L}}=+5.25 \mathrm{~V}$ |

## NOTES

${ }^{1}$ Temperature ranges are as follows: B Versions: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; T Versions: $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
${ }^{2}$ Guaranteed by design, not subject to production test.
Specifications subject to change without notice.

## Truth Table (ADG411/ADG412)

| ADG411 In | ADG412 In | Switch Condition |
| :--- | :--- | :--- |
| 0 | 1 | ON |
| 1 | 0 | OFF |

Truth Table (ADG413)

| Logic | Switch 1, 4 | Switch 2, 3 |
| :--- | :--- | :--- |
| 0 | OFF | ON |
| 1 | ON | OFF |

ABSOLUTE MAXIMUM RATINGS ${ }^{1}$
( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)
$V_{D D}$ to $V_{s s}$ ..... $+44 \mathrm{~V}$
$V_{D D}$ to GND ..... -0.3 V to +25 V
$\mathrm{V}_{\mathrm{ss}}$ to GND

$$
+0.3 \mathrm{~V} \text { to }-25 \mathrm{~V}
$$

$\mathrm{V}_{\mathrm{L}}$ to GND -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Analog, Digital Inputs ${ }^{2}$ $\mathrm{V}_{\mathrm{ss}}-2 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}+2 \mathrm{~V}$ or30 mA , whichever occurs first
Continuous Current, S or D ..... 30 mA
Peak Current, S or D ..... 100 mA
(Pulsed at $1 \mathrm{~ms}, 10 \%$ Duty Cycle max)
Operating Temperature RangeIndustrial (B Version) . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Extended (T Version) ..... $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range ..... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Junction Temperature ..... $+150^{\circ} \mathrm{C}$
Cerdip Package, Power Dissipation 900 mW
$\theta_{\mathrm{JA}}$ Thermal Impedance ..... $76^{\circ} \mathrm{C} / \mathrm{W}$
ESD SUSCEPTIBILITY
Lead Temperature, Soldering ( 10 sec ) ..... $+300^{\circ} \mathrm{C}$
Plastic Package, Power Dissipation ..... 470 mW
$\theta_{\mathrm{JA}}$ Thermal Impedance ..... $117^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature, Soldering ( 10 sec ) ..... $+260^{\circ} \mathrm{C}$
SOIC Package, Power Dissipation ..... 600 mW
$\theta_{\text {JA }}$ Thermal Impedance ..... $77^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature, Soldering
Vapor Phase (60 sec) . . . . . . . . . . . . . . . . . . . . $+215^{\circ} \mathrm{C}$
Infrared ( 15 sec ) ..... $+220^{\circ} \mathrm{C}$
NOTES
'Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Only one absolute maximum rating may be applied at any one time.
${ }^{2}$ Overvoltages at IN, S or D will be clamped by internal diodes. Current should be limited to the maximum ratings given.

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 volts, which readily accumulate on the human body and on test equipment, can discharge without detection. Although these devices feature proprietary ESD protection circuitry, permanent damage may still occur on these devices if they are subjected to high energy electrostatic discharges. Therefore,
 proper precautions are recommended to avoid any performance degradation or loss of functionality.

PIN CONFIGURATION (DIP/SOIC)


## ORDERING GUIDE

| Model $^{1}$ | Temperature Range | Package Option ${ }^{2,3}$ |
| :--- | :--- | :--- |
| ADG411BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| ADG411BR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16 \mathrm{~A}$. |
| ADG411TQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| ADG412BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| ADG412BR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16 \mathrm{~A}$ |
| ADG412TQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| ADG413BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| ADG413BR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16 \mathrm{~A}$ |

## NOTES

${ }^{1}$ To order MIL-STD-883, Class B processed parts, add /883B to T grade part numbers.
${ }^{2} \mathbf{N}=$ Plastic DIP; $\mathbf{R}=0.15^{\prime \prime}$ Small Outline IC (SOIC); $\mathbf{Q}=$ Cerdip.
${ }^{3}$ For outline information see Package Information section.

## TERMINOLOGY

| $\mathrm{V}_{\mathrm{DD}}$ | Most positive power supply potential. <br> Most negative power supply potential in dual <br> supplies. In single supply applications, it may <br> be connected to GND. |
| :--- | :--- |
| $\mathrm{V}_{\mathrm{ss}}$ | Logic power supply (+5 V). <br> $\mathrm{V}_{\mathrm{L}}$ |
| GND | Ground (0 V) reference. |
| S | Source terminal. May be an input or output. |
| D | Drain terminal. May be an input or output. |
| IN | Logic control input. |
| $\mathrm{R}_{\mathrm{ON}}$ | Ohmic resistance between D and S. |
| $\mathrm{I}_{\mathrm{s}}(\mathrm{OFF})$ | Source leakage current with the switch "OFF." |
| $\mathrm{I}_{\mathrm{D}}(\mathrm{OFF})$ | Drain leakage current with the switch "OFF." |
| $\mathrm{I}_{\mathrm{D}}, \mathrm{I}_{\mathrm{S}}(\mathrm{ON})$ | Channel leakage current with the switch "ON." |
| $\mathrm{V}_{\mathrm{D}}\left(\mathrm{V}_{\mathrm{S}}\right)$ | Analog voltage on terminals $\mathrm{D}, \mathrm{S}$. |
| $\mathrm{C}_{\mathrm{S}}(\mathrm{OFF})$ | "OFF" switch source capacitance. |
| $\mathrm{C}_{\mathrm{D}}(\mathrm{OFF})$ | "OFF" switch drain capacitance. |
| $\mathrm{C}_{\mathrm{D}}, \mathrm{C}_{\mathrm{S}}(\mathrm{ON})$ | "ON" switch capacitance. |


| $\mathrm{t}_{\mathrm{ON}}$ | Delay between applying the digital control <br> input and the output switching on. |
| :--- | :--- |
| $\mathrm{t}_{\mathrm{OFF}}$ | Delay between applying the digital control <br> input and the output switching off. |
| $\mathrm{t}_{\mathrm{D}}$ | "OFF" time or "ON" time measured between <br> the $90 \%$ points of both switches, when switching <br> from one address state to another. |
| Crosstalk | A measure of unwanted signal which is coupled <br> through from one channel to another as a result <br> of parasitic capacitance. |
| Off Isolation | A measure of unwanted signal coupling <br> through an "OFF" switch. |
| Charge | A measure of the glitch impulse transferred <br> from the digital input to the analog output <br> during switching. |
| Injection |  |

## Typical Performance Graphs



Figure 1. On Resistance as a Function of $V_{D}\left(V_{s}\right)$ Dual Supplies


Figure 2. On Resistance as a Function of $V_{D}\left(V_{S}\right)$ for Different Temperatures


Figure 3. Leakage Currents as a Function of Temperature


Figure 4. On Resistance as a Function of $V_{D}\left(V_{S}\right)$ Single Supply


Figure 5. Supply Current vs. Input Switching Frequency


Figure 6. Leakage Currents as a Function of $V_{D}\left(V_{S}\right)$


Figure 7. Off Isolation vs. Frequency


Figure 8. Crosstalk vs. Frequency

## TRENCH ISOLATION

In the ADG411, ADG412 and ADG413, an insulating oxide layer (trench) is placed between the NMOS and the PMOS transistors of each CMOS switch. Parasitic junctions, which occur between the transistors in Junction Isolated switches, are eliminated, the result being a completely latch-up proof switch.
In Junction Isolation, the N and P wells of the PMOS and NMOS transistors form a diode which is reverse-biased under normal operation. However, during overvoltage conditions, this diode becomes forward biased. A Silicon-Controlled Rectifier (SCR) type circuit is formed by the two transistors causing a significant amplification of the current which, in turn, leads to latch-up. With Trench Isolation, this diode is removed, the result being a latch-up proof switch.
Trench Isolation also leads to lower leakage currents. The ADG411, ADG412 and ADG413 have a leakage current of 0.25 nA as compared with a leakage current of several nanoamps in non-Trench Isolated switches. Leakage current is an important parameter in sample-and-hold circuits, this current being responsible for the discharge of the holding capacitor with time causing droop. The ADG411/ADG412/ADG413's low leakage current, along with its fast switching speeds, make it suitable for fast and accurate sample-and-hold circuits.


SUBSTRATE (BACKGATE)

Figure 9. Trench Isolation

## APPLICATION

Figure 10 illustrates a precise, fast sample-and-hold circuit. An AD845 is used as the input buffer while the output operational amplifier is an AD711. During the track mode, SW1 is closed and the output $\mathrm{V}_{\text {OUT }}$ follows the input signal $\mathrm{V}_{\mathrm{IN}}$. In the hold mode, SW1 is opened and the signal is held by the hold capacitor $\mathrm{C}_{\mathrm{H}}$.
Due to switch and capacitor leakage, the voltage on the hold capacitor will decrease with time. The ADG411/ADG412/ ADG413 minimizes this droop due to its low leakage specifications. The droop rate is further minimized by the use of a polystyrene hold capacitor. The droop rate for the circuit shown is typically $30 \mu \mathrm{~V} / \mu \mathrm{s}$.
A second switch SW2, which operates in parallel with SW1, is included in this circuit to reduce pedestal error. Since both switches will be at the same potential, they will have a differential effect on the op amp AD711 which will minimize charge injection effects. Pedestal error is also reduced by the compensation network $\mathrm{R}_{\mathrm{C}}$ and $\mathrm{C}_{\mathrm{C}}$. This compensation network also reduces the hold time glitch while optimizing the acquisition time. Using the illustrated op amps and component values, the pedestal error has a maximum value of 5 mV over the $\pm 10 \mathrm{~V}$ input range. Both the acquisition and settling times are 850 ns .


Figure 10. Fast, Accurate Sample-and-Hold

## ADG411/ADG412/ADG413

## Test Circuits



Test Circuit 1. On Resistance


Test Circuit 2. Off Leakage


Test Circuit 3. On Leakage


Test Circuit 4. Switching Times


Test Circuit 5. Break-Before-Make Time Delay


Test Circuit 6. Charge Injection


Test Circuit 7. Off Isolation


Test Circuit 8. Channel-to-Channel Crosstalk

FEATURES
44 V Supply Maximum Ratings
$\mathbf{V}_{\text {ss }}$ to $\mathbf{V}_{\text {DD }}$ Analog Signal Range
Low On Resistance (< $35 \Omega$ )
Ultralow Power Dissipation ( $<\mathbf{3 5 \mu W}$ )
Fast Transition Time (145 ns max)
Break-Before-Make Switching Action
Latch-Up Proof
Plug-In Replacement for DG419
APPLICATIONS
Precision Test Equipment
Precision Instrumentation
Battery Powered Systems
Sample Hold Systems

## GENERAL DESCRIPTION

The ADG419 is a monolithic CMOS SPDT switch. This switch is designed on an enhanced LC $^{2}$ MOS process which provides low power dissipation yet gives high switching speed, low on resistance and low leakage currents.
The on resistance profile of the ADG419 is very flat over the full analog input range ensuring excellent linearity and low distortion. The part also exhibits high switching speed and high signal bandwidth. CMOS construction ensures ultralow power dissipation making the parts ideally suited for portable and battery powered instruments.

Each switch of the ADG419 conducts equally well in both directions when ON and has an input signal range which extends to the supplies. In the OFF condition, signal levels up to the supplies are blocked. The ADG419 exhibits break-beforemake switching action.

FUNCTIONAL BLOCK DIAGRAM


SWITCH SHOWN FOR A LOGIC "1" INPUT

## PRODUCT HIGHLIGHTS

1. Extended Signal Range

The ADG419 is fabricated on an enhanced LC ${ }^{2}$ MOS, trench isolated process giving an increased signal range that extends to the supply rails.
2. Ultralow Power Dissipation
3. Low $\mathrm{R}_{\mathrm{ON}}$
4. Trench Isolation Guards Against Latch Up

A dielectric trench separates the P and N channel transistors thereby preventing latch-up even under severe overvoltage conditions
5. Single Supply Operation

For applications where the analog signal is unipolar, the ADG419 can be operated from a single rail power supply. The part is fully specified with a single +12 V power supply and will remain functional with single supplies as low as +5 V .

This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

Dual Supply ( $\mathrm{V}_{\mathrm{DD}}=+15 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{S S}=-15 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{\mathrm{L}}=+5 \mathrm{~V} \pm 10 \%$, $\mathrm{GND}=0 \mathrm{~V}$, unless otherwise noted)

| Parameter | B Version |  | T Version |  | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | $+25^{\circ} \mathrm{C}$ | $\begin{aligned} & -40^{\circ} \mathrm{C} \text { to } \\ & +85^{\circ} \mathrm{C} \\ & \hline \end{aligned}$ | $+25^{\circ} \mathrm{C}$ | $\begin{aligned} & -55^{\circ} \mathrm{C} \text { to } \\ & +125^{\circ} \mathrm{C} \\ & \hline \end{aligned}$ |  |  |
| ANALOG SWITCH Analog Signal Range $\mathrm{R}_{\mathrm{ON}}$ | $\begin{aligned} & 25 \\ & 35 \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{SS}} \text { to } \mathrm{V}_{\mathrm{DD}} \\ & 45 \end{aligned}$ | $\begin{aligned} & 25 \\ & 35 \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{SS}} \text { to } \mathrm{V}_{\mathrm{DD}} \\ & 45 \end{aligned}$ | V <br> $\Omega$ typ <br> $\Omega$ max | $\begin{aligned} & \mathrm{V}_{\mathrm{D}}= \pm 12.5 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=-10 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{DD}}=+13.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=-13.5 \mathrm{~V} \end{aligned}$ |
| LEAKAGE CURRENTS <br> Source OFF Leakage IS (OFF) <br> Drain OFF Leakage $\mathrm{I}_{\mathrm{D}}$ (OFF) <br> Channel ON Leakage $\mathrm{I}_{\mathrm{D}}, \mathrm{I}_{\mathrm{S}}(\mathrm{ON})$ | $\begin{aligned} & \pm 0.1 \\ & \pm 0.25 \\ & \pm 0.1 \\ & \pm 0.75 \\ & \pm 0.4 \\ & \pm 0.75 \end{aligned}$ | $\pm 5$ $\pm 5$ $\pm 5$ | $\begin{aligned} & \pm 0.1 \\ & \pm 0.25 \\ & \pm 0.1 \\ & \pm 0.75 \\ & \pm 0.4 \\ & \pm 0.75 \end{aligned}$ | $\begin{aligned} & \pm 15 \\ & \pm 30 \\ & \pm 30 \end{aligned}$ | nA typ nA max nA typ nA max nA typ $\mathrm{nA} \max$ | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=+16.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=-16.5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{D}}= \pm 15.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{S}}=\mp 15.5 \mathrm{~V} ; \\ & \text { Test Circuit } 2 \\ & \mathrm{~V}_{\mathrm{D}}= \pm 15.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{s}}=\mp 15.5 \mathrm{~V} \text {; } \\ & \text { Test Circuit } 2 \\ & \mathrm{~V}_{\mathrm{S}}=\mathrm{V}_{\mathrm{D}}= \pm 15.5 \mathrm{~V} ; \\ & \text { Test Circuit } 3 \end{aligned}$ |
| DIGITAL INPUTS <br> Input High Voltage, $\mathrm{V}_{\text {INH }}$ Input Low Voltage, $\mathrm{V}_{\text {INL }}$ Input Current $\mathrm{I}_{\text {INL }}$ or $\mathrm{I}_{\text {INH }}$ |  | $\begin{aligned} & 2.4 \\ & 0.8 \\ & \pm 0.005 \\ & \pm 0.5 \end{aligned}$ |  | $\begin{aligned} & 2.4 \\ & 0.8 \\ & \\ & \pm 0.005 \\ & \pm 0.5 \end{aligned}$ | $V$ min <br> V max <br> $\mu \mathrm{A}$ typ <br> $\mu \mathrm{A}$ max | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {INL }}$ or $\mathrm{V}_{\text {INH }}$ |
| DYNAMIC CHARACTERISTICS ${ }^{2}$ <br> $\mathrm{t}_{\text {TRANSITION }}$ | 145 | 200 | $145$ | 200 | ns max | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF} ; \\ & \mathrm{V}_{\mathrm{S} 1}= \pm 10 \mathrm{~V}, \mathrm{~V}_{\mathrm{S} 2}=\mp 10 \mathrm{~V} ; \\ & \text { Test Circuit } 4 \end{aligned}$ |
| Break-Before-Make Time Delay, $t_{D}$ | $\begin{aligned} & 30 \\ & 5 \end{aligned}$ |  | $\begin{aligned} & 30 \\ & 5 \end{aligned}$ |  | ns typ ns min | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF} ; \\ & \mathrm{V}_{\mathrm{S} 1}=\mathrm{V}_{\mathrm{S} 2}= \pm 10 \mathrm{~V} ; \\ & \text { Test Circuit } 5 \end{aligned}$ |
| OFF Isolation | 80 |  | 80 |  | dB typ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{f}=1 \mathrm{MHz} \text {; } \\ & \text { Test Circuit } 6 \end{aligned}$ |
| Channel-to-Channel Crosstalk | 70 |  | 70 |  | dB typ | $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{f}=1 \mathrm{MHz}$ <br> Test Circuit 7 |
| $\begin{aligned} & \mathrm{C}_{\mathrm{S}}(\mathrm{OFF}) \\ & \mathrm{C}_{\mathrm{D}}, \mathrm{C}_{\mathrm{S}}(\mathrm{ON}) \end{aligned}$ | 6 55 |  | $\begin{aligned} & 6 \\ & 55 \end{aligned}$ |  | $\mathrm{pF} \text { typ }$ $\mathrm{pF} \text { typ }$ | $\begin{aligned} & \mathrm{f}=1 \mathrm{MHz} \\ & \mathrm{f}=1 \mathrm{MHz} \end{aligned}$ |
| POWER REQUIREMENTS $\mathrm{I}_{\mathrm{DD}}$ | 0.0001 |  | 0.0001 |  | $\mu \mathrm{A}$ typ <br> $\mu \mathrm{A}$ max | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=+16.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{ss}}=-16.5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V} \text { or } 5 \mathrm{~V} \end{aligned}$ |
|  |  | 2.5 |  | 2.5 |  |  |
| $\mathrm{I}_{\text {SS }}$ | 0.0001 |  | 0.0001 |  | $\mu \mathrm{A}$ typ |  |
|  | 1 0.0001 | 2.5 | $\begin{aligned} & 1 \\ & 0.0001 \end{aligned}$ | 2.5 | $\mu \mathrm{A}$ max $\mu \mathrm{A}$ typ | $\mathrm{V}_{\mathrm{L}}=+5.5 \mathrm{~V}$ |
| $\mathrm{I}_{\mathrm{L}}$ |  | 2.5 |  | 2.5 | $\mu \mathrm{A}$ max |  |

NOTES
${ }^{1}$ Temperature ranges are as follows: B Version: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; T Version: $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
${ }^{2}$ Guaranteed by design, not subject to production test.
Specifications subject to change without notice.

Single Supply $\left(\mathrm{V}_{00}=+12 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=+5 \mathrm{~V} \pm 10 \%\right.$, $\mathrm{GND}=0 \mathrm{~V}$, unless otherwise noted)

| Parameter | B Version |  | T Version |  | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | ${ }^{+}+\mathbf{2 5}{ }^{\circ} \mathrm{C}$ | $\begin{aligned} & -40^{\circ} \mathrm{C} \text { to } \\ & +85^{\circ} \mathrm{C} \end{aligned}$ | $+25^{\circ} \mathrm{C}$ | $\begin{aligned} & -55^{\circ} \mathrm{C} \text { to } \\ & +125^{\circ} \mathrm{C} \end{aligned}$ |  |  |
| ANALOG SWITCH Analog Signal Range $\mathrm{R}_{\mathrm{ON}}$ | 40 | 0 to $V_{D D}$ <br> 60 | 40 | $0 \text { to } \mathrm{V}_{\mathrm{DD}}$ <br> 70 | V <br> $\Omega$ typ $\Omega$ max | $\begin{aligned} & \mathrm{V}_{\mathrm{D}}=+3 \mathrm{~V},+8.5 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=-10 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{DD}}=+10.8 \mathrm{~V} \end{aligned}$ |
| LEAKAGE CURRENT <br> Source OFF Leakage $\mathrm{I}_{\mathrm{S}}$ (OFF) <br> Drain OFF Leakage $\mathrm{I}_{\mathrm{D}}(\mathrm{OFF})$ <br> Channel ON Leakage $\mathrm{I}_{\mathrm{D}}, \mathrm{I}_{\mathrm{S}}(\mathrm{ON})$ | $\begin{aligned} & \pm 0.1 \\ & \pm 0.25 \\ & \pm 0.1 \\ & \pm 0.75 \\ & \pm 0.4 \\ & \pm 0.75 \end{aligned}$ | $\begin{aligned} & \pm 5 \\ & \pm 5 \\ & \pm 5 \end{aligned}$ | $\begin{aligned} & \pm 0.1 \\ & \pm 0.25 \\ & \pm 0.1 \\ & \pm 0.75 \\ & \pm 0.4 \\ & \pm 0.75 \end{aligned}$ | $\begin{aligned} & \pm 15 \\ & \pm 30 \\ & \pm 30 \end{aligned}$ | nA typ <br> nA max <br> nA typ <br> nA max <br> nA typ <br> nA max | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=+13.2 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{D}}=12.2 \mathrm{~V} / 1 \mathrm{~V}, \mathrm{~V}_{\mathrm{S}}=1 \mathrm{~V} / 12.2 \mathrm{~V} ; \\ & \text { Test Circuit } 2 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{D}}=12.2 \mathrm{~V} / 1 \mathrm{~V}, \mathrm{~V}_{\mathrm{S}}=1 \mathrm{~V} / 12.2 \mathrm{~V} ; \\ & \text { Test Circuit } 2 \\ & \mathrm{~V}_{\mathrm{S}}=\mathrm{V}_{\mathrm{D}}=12.2 \mathrm{~V} / 1 \mathrm{~V} ; \\ & \text { Test Circuit } 3 \end{aligned}$ |
| DIGITAL INPUTS <br> Input High Voltage, $\mathrm{V}_{\text {INH }}$ Input Low Voltage, VINL Input Current $\mathrm{I}_{\mathrm{INL}}$ or $\mathrm{I}_{\mathrm{INH}}$ |  | $\begin{aligned} & 2.4 \\ & 0.8 \\ & \pm 0.005 \\ & \pm 0.5 \end{aligned}$ |  | $\begin{aligned} & 2.4 \\ & 0.8 \\ & \\ & \pm 0.005 \\ & \pm 0.5 \end{aligned}$ | $V$ min <br> V max <br> $\mu \mathrm{A}$ typ <br> $\mu \mathrm{A}$ max | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {INL }}$ or $\mathrm{V}_{\text {INH }}$ |
| DYNAMIC CHARACTERISTICS ${ }^{2}$ <br> ${ }^{\text {t }}$ transition <br> Break-Before-Make Time <br> Delay, $t_{D}$ <br> OFF Isolation <br> Channel-to-Channel Crosstalk <br> $\mathrm{C}_{\mathrm{S}}$ (OFF) <br> $\mathrm{C}_{\mathrm{D}}, \mathrm{C}_{\mathrm{S}}(\mathrm{ON})$ | $\begin{aligned} & 170 \\ & 60 \\ & 80 \\ & 70 \\ & 13 \\ & 65 \end{aligned}$ | 250 | $\begin{aligned} & 170 \\ & 60 \\ & 80 \\ & 80 \\ & 70 \\ & 13 \\ & 65 \\ & \hline \end{aligned}$ | 250 | ns max <br> ns typ <br> dB typ <br> dB typ <br> pF typ <br> pF typ | $\mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF} ;$ <br> $\mathrm{V}_{\mathrm{S} 1}=0 \mathrm{~V} / 8 \mathrm{~V}, \mathrm{~V}_{\mathrm{S} 2}=8 \mathrm{~V} / 0 \mathrm{~V}$; <br> Test Circuit 4 $\mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF} ;$ <br> $\mathrm{V}_{\mathrm{S}_{1}}=\mathrm{V}_{\mathrm{S} 2}=+8 \mathrm{~V}$; <br> Test Circuit 5 $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{f}=1 \mathrm{MHz}$ <br> Test Circuit 6 $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{f}=1 \mathrm{MHz}$ <br> Test Circuit 7 $\mathrm{f}=1 \mathrm{MHz}$ $\mathrm{f}=1 \mathrm{MHz}$ |
| POWER REQUIREMENTS $\mathrm{I}_{\mathrm{DD}}$ $\mathrm{I}_{\mathrm{L}}$ | $\begin{aligned} & 0.0001 \\ & 1 \\ & 0.0001 \\ & 1 \end{aligned}$ | $\begin{aligned} & 2.5 \\ & 2.5 \end{aligned}$ | $\begin{aligned} & 0.0001 \\ & 1 \\ & 0.0001 \\ & 1 \end{aligned}$ | $\begin{aligned} & 2.5 \\ & 2.5 \end{aligned}$ | $\mu \mathrm{A}$ typ $\mu \mathrm{A}$ max $\mu \mathrm{A}$ typ $\mu \mathrm{A}$ max | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=+13.2 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V} \text { or } 5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{L}}=+5.5 \mathrm{~V} \end{aligned}$ |

## NOTES

${ }^{1}$ Temperature ranges are as follows: B Version: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; T Version: $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
${ }^{2}$ Guaranteed by design, not subject to production test.
Specifications subject to change without notice.

Table I. Truth Table

| Logic | Switch 1 | Switch 2 |
| :--- | :--- | :--- |
| 0 | ON | OFF |
| 1 | OFF | ON |

ORDERING GUIDE

| Model | Temperature Range | Package Option |
| :--- | :--- | :--- |
| ADG419BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| ADG419BR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | SO-8 |
| ADG419TQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |

${ }^{\star} \mathrm{N}=$ Plastic DIP, $\mathrm{Q}=$ Cerdip, $\mathrm{SO}=0.15^{\prime \prime}$ Small Outline IC (SOIC). For outline information see Package Information section.

## PIN CONFIGURATION

 DIP/SOIC
ABSOLUTE MAXIMUM RATINGS ${ }^{1}$
( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)
$\mathrm{V}_{\mathrm{DD}}$ to $\mathrm{V}_{\text {ss }}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . +44 V
$\mathrm{V}_{\mathrm{DD}}$ to GND . . . . . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to +25 V
$\mathrm{V}_{\text {Ss }}$ to GND . . . . . . . . . . . . . . . . . . . . . . . . . . +0.3 V to -25 V
$\mathrm{V}_{\mathrm{L}}$ to GND . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Analog, Digital Inputs ${ }^{2}$. . . . . . . . . . . . $\mathrm{V}_{\mathrm{Ss}}-2 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}+2 \mathrm{~V}$or 30 mA , Whichever Occurs First
Continuous Current, S or D ..... 30 mA
Peak Current, S or D ..... 100 mA
(Pulsed at $1 \mathrm{~ms}, 10 \%$ Duty Cycle Max)
Operating Temperature Range
Industrial (B Version) . . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Extended (T Version) . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range ..... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Junction Temperature .....  $150^{\circ} \mathrm{C}$
Cerdip Package, Power Dissipation ..... 600 mW
$\theta_{\mathrm{JA}}$, Thermal Impedance ..... $110^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature, Soldering ( 10 sec ) ..... $+300^{\circ} \mathrm{C}$
Plastic Package, Power Dissipation ..... 400 mW
$\theta_{\mathrm{JA}}$, Thermal Impedance ..... $100^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature, Soldering (10 sec) ..... $+260^{\circ} \mathrm{C}$
SOIC Package, Power Dissipation ..... 400 mW
$\theta_{\mathrm{JA}}$, Thermal Impedance ..... $155^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature, Soldering
Vapor Phase ( 60 sec ) ..... $+215^{\circ} \mathrm{C}$
Infrared (15 sec) ..... $+220^{\circ} \mathrm{C}$

## NOTE

Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Only one absolute maximum rating may be applied at any one time.
${ }^{2}$ Overvoltages at $\mathrm{IN}, \mathrm{S}$ or D will be clamped by internal diodes. Current should be limited to the maximum ratings given.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this device features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

## TERMINOLOGY

| $\mathrm{V}_{\mathrm{DD}}$ | Most positive power supply potential. <br> Most negative power supply potential in dual <br> supplies. In single supply applications, it <br> may be connected to GND. |
| :--- | :--- |
| $\mathrm{V}_{\mathrm{SS}}$ | Logic power supply (+5 V). |
| $\mathrm{V}_{\mathrm{L}}$ | Ground (0 V) reference. <br> Source terminal. May be an input or an <br> output. |
| GND | Drain terminal. May be an input or an <br> output. |
| S | Logic control input. <br> Ohmic resistance between D and S. |
| IN | Source leakage current with the switch <br> "OFF." |
| $\mathrm{R}_{\mathrm{ON}}$ | Drain leakage current with the switch <br> $\mathrm{I}_{\mathrm{S}}(\mathrm{OFF})$ |
| $\mathrm{I}_{\mathrm{D}}(\mathrm{OFF})$ | "OFF." |
| $\mathrm{I}_{\mathrm{D}}, \mathrm{I}_{\mathrm{S}}(\mathrm{ON})$ | Channel leakage current with the switch <br> "ON." |
| $\mathrm{V}_{\mathrm{D}}\left(\mathrm{V}_{\mathrm{S}}\right)$ | Analog voltage on terminals $\mathrm{D}, \mathrm{S}$. <br> $\mathrm{C}_{S}(\mathrm{OFF})$ |
| "OFF" switch source capacitance. |  |


| $\mathrm{C}_{\mathrm{D}}, \mathrm{C}_{\mathrm{S}}(\mathrm{ON})$ | "ON" switch capacitance. |
| :---: | :---: |
| $\mathrm{t}_{\text {TRANSITION }}$ | Delay time between the $50 \%$ and $90 \%$ points. of the digital inputs and the switch "ON" condition when switching from one address state to another. |
| $t_{\text {D }}$ | "OFF" time or "ON" time measured between the $90 \%$ points of both switches when switching from one address state to the other. |
| $\mathrm{V}_{\text {INL }}$ | Maximum input voltage for logic " 0 ." |
| $\mathrm{V}_{\text {INH }}$ | Minimum input voltage for logic " 1 ." |
| $\mathrm{I}_{\text {INL }}\left(\mathrm{I}_{\text {INH }}\right)$ | Input current of the digital input. |
| Crosstalk | A measure of unwanted signal which is coupled through from one channel to another as a result of parasitic capacitance. |
| Off Isolation | A measure of unwanted signal coupling through an "OFF" channel. |
| $\mathrm{I}_{\mathrm{DD}}$ | Positive supply current. |
| $\mathrm{I}_{\text {S }}$ | Negative supply current. |

## FEATURES

44 V Supply Maximum Ratings
$\mathbf{V}_{\text {ss }}$ to $\mathbf{V}_{\text {DD }}$ Analog Signal Range
Low On Resistance ( $60 \Omega$ typ)
Low Power Consumption ( 1.6 mW max)
Low Charge Injection (<4 pC typ)
Fast Switching
Break Before make Switching Action
Plug-In Replacement for DG428/DG429

## APPLICATIONS

Automatic Test Equipment
Data Acquisition Systems

## Communication Systems

Avionics and Military Systems
Microprocessor Controlled Analog Systems
Medical Instrumentation

## GENERAL DESCRIPTION

The ADG428 and ADG429 are monolithic CMOS analog multiplexers comprising eight single channels and four differential channels respectively. On-chip address and control latches facilitate microprocessor interfacing. The ADG428 switches one of eight inputs to a common output as determined by the 3-bit binary address lines A0, A1 and A2. The ADG429 switches one of four differential inputs to a common differential output as determined by the 2 bit binary address lines A0 and A1. An EN input on both devices is used to enable or disable the device. When disabled, all channels are switched OFF. All the control inputs, address and enable inputs are TTL compatible over the full specified operating temperature range. This makes the part suitable for bus-controlled systems such as data acquisition systems, process controls, avionics and ATEs because the TTL compatible address latches simplify the digital interface design and reduce the board space required.
The ADG428/ADG429 are designed on an enhanced LC $^{2}$ MOS process that provides low power dissipation yet gives high switching speed and low on resistance. Each channel conducts equally well in both directions when ON and has an input signal range that extends to the supplies. In the OFF condition, signal levels up to the supplies are blocked. All channels exhibit break before make switching action preventing momentary shorting when switching channels. Inherent in the design is low charge injection for minimum transients when switching the digital inputs.
The ADG428/ADG429 are improved replacements for the DG428/DG429 Analog Multiplexers.

FUNCTIONAL BLOCK DIAGRAMS


## PRODUCT HIGHLIGHTS

1. Extended Signal Range

The ADG428/ADG429 are fabricated on an enhanced $L^{2}$ MOS process giving an increased signal range that extends to the supply rails.
2. Low Power Dissipation
3. Low $\mathrm{R}_{\mathrm{ON}}$
4. Single/Dual Supply Operation
5. Single Supply Operation

For applications where the analog signal is unipolar, the ADG428/ADG429 can be operated from a single rail power supply. The parts are fully specified with a single +12 V power supply and will remain functional with single supplies as low as +5 V .

This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.


| Parameter | $\begin{array}{\|r} \text { B } \\ 25^{\circ} \mathrm{C} \end{array}$ | $\begin{aligned} & \text { Version } \\ & -40^{\circ} \mathrm{C} \text { to } \\ & +85^{\circ} \mathrm{C} \end{aligned}$ | $\begin{array}{r} \mathrm{T} \\ 25^{\circ} \mathrm{C} \end{array}$ | $\begin{aligned} & \text { Version } \\ & -55^{\circ} \mathrm{C} \text { to } \\ & +125^{\circ} \mathrm{C} \end{aligned}$ | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ANALOG SWITCH <br> Analog Signal Range $\mathrm{R}_{\mathrm{ON}}$. $\Delta \mathrm{R}_{\mathrm{ON}}$ | $\begin{array}{\|l\|l} 60 \\ 100 \\ 10 \end{array}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{SS}} \text { to } \mathrm{V}_{\mathrm{DD}} \\ & 125 \end{aligned}$ | $\begin{array}{\|l\|} \hline 60 \\ 100 \\ 10 \end{array}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{SS}} \text { to } \mathrm{V}_{\mathrm{DD}} \\ & 125 \end{aligned}$ | V <br> $\Omega$ typ <br> $\Omega$ max <br> \% max | $\begin{aligned} & \mathrm{V}_{\mathrm{D}}= \pm 10 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=-1 \mathrm{~mA} \\ & -10 \mathrm{~V}<\mathrm{V}_{\mathrm{S}}<10 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=-1 \mathrm{~mA} \end{aligned}$ |
| ```LEAKAGE CURRENTS Source OFF Leakage I (OFF) Drain OFF Leakage \(I_{D}(O F F)\) ADG428 ADG429 Channel ON Leakage \(I_{D}, I_{S}\) (ON) ADG428 ADG429``` | $\begin{aligned} & \pm 0.03 \\ & \pm 0.5 \\ & \pm 0.07 \\ & \pm 1 \\ & \pm 0.05 \\ & \pm 1 \\ & \\ & \pm 1 \\ & \pm 1 \end{aligned}$ | $\begin{aligned} & \pm 0.3 \\ & \pm 50 \\ & \\ & \pm 0.7 \\ & \pm 100 \\ & \pm 0.5 \\ & \pm 50 \\ & \\ & \pm 100 \\ & \pm 50 \end{aligned}$ | $\begin{aligned} & \pm 0.03 \\ & \pm 0.5 \\ & \pm 0.07 \\ & \pm 1 \\ & \pm 0.05 \\ & \pm 1 \\ & \\ & \pm 1 \\ & \pm 1 \end{aligned}$ | $\begin{aligned} & \pm 0.3 \\ & \pm 50 \\ & \\ & \pm 0.7 \\ & \pm 100 \\ & \pm 0.5 \\ & \pm 50 \\ & \\ & \pm 100 \\ & \pm 50 \end{aligned}$ | nA typ nA max <br> nA typ nA max nA typ nA max <br> nA max nA max | $\mathrm{V}_{\mathrm{D}}= \pm 10 \mathrm{~V}, \mathrm{~V}_{\mathrm{S}}=\mp 10 \mathrm{~V} \text {; }$ <br> Test Circuit 2 $\mathrm{V}_{\mathrm{D}}= \pm 10 \mathrm{~V}, \mathrm{~V}_{\mathrm{S}}=\mp 10 \mathrm{~V}$ <br> Test Circuit 3 $\mathrm{V}_{\mathrm{S}}=\mathrm{V}_{\mathrm{D}}= \pm 10 \mathrm{~V}$ <br> Test Circuit 4 |
| DIGITAL INPUTS <br> Input High Voltage, $\mathrm{V}_{\text {INH }}$ <br> Input Low Voltage, $\mathrm{V}_{\text {INL }}$ <br> Input Current <br> $\mathrm{I}_{\text {INL }}$ or $\mathrm{I}_{\text {INH }}$ <br> $\mathrm{C}_{\text {IN }}$, Digital Input Capacitance | $\begin{aligned} & \pm 0.1 \\ & 8 \end{aligned}$ | 2.4 0.8 $\pm 1$ | $\begin{array}{\|l}  \pm 0.1 \\ 8 \end{array}$ | $\begin{aligned} & 2.4 \\ & 0.8 \\ & \\ & \pm 1 \end{aligned}$ | V min V max $\mu \mathrm{A}$ max pF typ | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=0 \text { or } \mathrm{V}_{\mathrm{DD}} \\ & \mathrm{f}=1 \mathrm{MHz} \end{aligned}$ |
| DYNAMIC CHARACTERISTICS ${ }^{2}$ <br> $\mathrm{t}_{\text {TRANSITION }}$ <br> $t_{\text {OPEN }}$ <br> $\mathrm{t}_{\mathrm{ON}}(\mathrm{EN}, \overline{\mathrm{WR}})$ <br> $\mathrm{t}_{\mathrm{OFF}}(\mathrm{EN}, \overline{\mathrm{RS}})$ <br> $\mathrm{t}_{\mathrm{w}}$, Write Pulse Width <br> $\mathrm{t}_{\mathrm{s}}$, Address, Enable Setup Time <br> $\mathrm{t}_{\mathrm{H}}$, Address, Enable Hold Time <br> $\mathrm{t}_{\mathrm{RS}}$, Reset Pulse Width <br> Charge Injection <br> OFF Isolation <br> Channel-to-Channel Crosstalk <br> $\mathrm{C}_{\mathrm{S}}$ (OFF) <br> $\mathrm{C}_{\mathrm{D}}$ (OFF) <br> ADG428 <br> ADG429 <br> $\mathrm{C}_{\mathrm{D}}, \mathrm{C}_{\mathrm{S}}(\mathrm{ON})$ <br> ADG428 <br> ADG429 | $\begin{array}{\|l} 110 \\ 250 \\ \\ 115 \\ 150 \\ 105 \\ 150 \\ \\ \\ 4 \\ -75 \\ -60 \\ 85 \\ 11 \\ 40 \\ 40 \\ 20 \\ 54 \\ 34 \end{array}$ | 300 <br> 10 <br> 225 <br> 300 <br> 100 <br> 100 <br> 10 <br> 100 | $\begin{array}{\|l} 110 \\ 250 \\ \\ 115 \\ 150 \\ 105 \\ 150 \\ \\ \\ 4 \\ -75 \\ -60 \\ 85 \\ 11 \\ \\ 40 \\ 20 \\ 54 \\ 34 \end{array}$ | $\begin{aligned} & 300 \\ & 10 \\ & 225 \\ & \\ & 300 \\ & 100 \\ & 100 \\ & 10 \\ & 100 \end{aligned}$ | ns typ ns max ns min ns typ ns max ns typ ns max ns min ns min ns min ns min pC typ dB typ dB min dB typ pF typ pF typ pF typ pF typ pF typ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=1 \mathrm{M} \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF} ; \\ & \mathrm{V}_{\mathrm{S} 1}= \pm 10 \mathrm{~V}, \mathrm{~V}_{\mathrm{S} 8}=\mp 10 \mathrm{~V} ; \\ & \text { Test Circuit } 5 \\ & \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF} ; \\ & \mathrm{V}_{\mathrm{S}}=+5 \mathrm{~V} ; \text { Test Circuit } 6 \\ & \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF} ; \\ & \mathrm{V}_{\mathrm{S}}=+5 \mathrm{~V} ; \text { Test Circuit } 7 \\ & \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF} ; \\ & \mathrm{V}_{\mathrm{S}}=+5 \mathrm{~V} ; \text { Test Circuit } 7 \\ & \\ & \\ & \\ & \mathrm{~V}_{\mathrm{S}}=+5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{S}}=0 \Omega, \mathrm{C}_{\mathrm{L}}=10 \mathrm{nF} ; \\ & \text { Test } \mathrm{Circuit} 10 \\ & \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}, \mathrm{f}=100 \mathrm{kHz} ; \\ & \mathrm{V}_{\mathrm{S}}=7 \mathrm{~V} \mathrm{~V}_{\mathrm{RMS}}, \mathrm{~V}_{\mathrm{EN}}=0 \mathrm{~V} ; \text { Test Circuit } 11 \\ & \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}, \mathrm{f}=100 \mathrm{kHz} ; \\ & \mathrm{Test} \operatorname{Circuit~} 12 \\ & \mathrm{f}=1 \mathrm{MHz} \\ & \mathrm{f}=1 \mathrm{MHz} \\ & \\ & \mathrm{f}=1 \mathrm{MHz} \end{aligned}$ |
| POWER REQUIREMENTS $I_{D D}$ $\mathrm{I}_{\mathrm{ss}}$ | $\begin{aligned} & 20 \\ & 100 \\ & 0.001 \\ & 5 \end{aligned}$ |  | $\begin{aligned} & 20 \\ & 100 \\ & 0.001 \\ & 5 \end{aligned}$ |  | $\mu \mathrm{A}$ typ $\mu \mathrm{A}$ max $\mu \mathrm{A}$ typ $\mu \mathrm{A}$ max | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{EN}}=0 \mathrm{~V}$ |

[^95]SINGLE SUPPLY $\left(\mathrm{V}_{\mathrm{oD}}=+12 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{GNO}=\mathrm{OV}, \overline{\mathrm{WR}}=\mathrm{OV}, \overline{\mathrm{SS}}=2.4 \mathrm{~V}\right.$ unless otherwise noted)

| Parameter | $\begin{array}{\|c} \mid \mathrm{B} \mathrm{~V} \\ 25^{\circ} \mathrm{C} \end{array}$ | $\begin{aligned} & \text { ersion } \\ & -40^{\circ} \mathrm{C} \text { to } \\ & +85^{\circ} \mathrm{C} \end{aligned}$ | $\begin{array}{r} \mathrm{TV} \\ 25^{\circ} \mathrm{C} \end{array}$ | $\begin{aligned} & \text { ersion } \\ & -55^{\circ} \mathrm{C} \text { to } \\ & +125^{\circ} \mathrm{C} \end{aligned}$ | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ANALOG SWITCH <br> Analog Signal Range $\mathrm{R}_{\mathrm{ON}}$ $\Delta \mathbf{R}_{\mathrm{ON}}$ | $\begin{aligned} & 90 \\ & 10 \end{aligned}$ | $\begin{aligned} & 0 \text { to } V_{D D} \\ & 200 \end{aligned}$ | $\begin{aligned} & 90 \\ & 10 \end{aligned}$ | $\begin{aligned} & 0 \text { to } V_{D D} \\ & 200 \end{aligned}$ | V $\Omega$ typ $\Omega$ max \% max | $\begin{aligned} & \mathrm{V}_{\mathrm{D}}=+10 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=-500 \mu \mathrm{~A} \\ & 0 \mathrm{~V}<\mathrm{V}_{\mathrm{S}}<10 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=-1 \mathrm{~mA} \end{aligned}$ |
| LEAKAGE CURRENTS <br> Source OFF Leakage $\mathrm{I}_{\mathrm{S}}$ (OFF) <br> Drain OFF Leakage $I_{D}$ (OFF) ADG428 <br> ADG429 <br> Channel ON Leakage $I_{D}, I_{S}(O N)$ ADG428 <br> ADG429 | $\begin{aligned} & \pm 0.005 \\ & \pm 0.5 \\ & \pm 0.015 \\ & \pm 1 \\ & \pm 0.008 \\ & \pm 1 \\ & \\ & \pm 0.02 \\ & \pm 1 \\ & \pm 0.01 \\ & \pm 1 \end{aligned}$ | $\begin{aligned} & \pm 50 \\ & \pm 100 \\ & \pm 50 \\ & \pm 100 \\ & \pm 50 \end{aligned}$ | $\begin{aligned} & \pm 0.005 \\ & \pm 0.5 \\ & \pm 0.015 \\ & \pm 1 \\ & \pm 0.008 \\ & \pm 1 \\ & \pm 0.02 \\ & \pm 1 \\ & \pm 0.01 \\ & \pm 1 \end{aligned}$ | $\begin{aligned} & \pm 50 \\ & \pm 100 \\ & \pm 50 \\ & \pm 100 \\ & \pm 50 \end{aligned}$ | nA typ nA max <br> nA typ $n A \max$ nA typ nA max <br> nA typ nA max nA typ $n A \max$ | $\mathrm{V}_{\mathrm{D}}=10 \mathrm{~V} / 0 \mathrm{~V}, \mathrm{~V}_{\mathrm{s}}=0 \mathrm{~V} / 10 \mathrm{~V}$ <br> Test Circuit 2 $\mathrm{V}_{\mathrm{D}}=10 \mathrm{~V} / 0 \mathrm{~V}, \mathrm{~V}_{\mathrm{S}}=0 \mathrm{~V} / 10 \mathrm{~V}$ <br> Test Circuit 3 $\mathrm{V}_{\mathrm{s}}=\mathrm{V}_{\mathrm{D}}=10 \mathrm{~V} / 0 \mathrm{~V}$ <br> Test Circuit 4 |
| DIGITAL INPUTS <br> Input High Voltage, $\mathrm{V}_{\text {INH }}$ <br> Input Low Voltage, $\mathrm{V}_{\text {INL }}$ <br> Input Current <br> $\mathrm{I}_{\text {INL }}$ or $\mathrm{I}_{\text {INH }}$ <br> $\mathrm{C}_{\text {IN }}$, Digital Input Capacitance | 8 | 2.4 0.8 $\pm 1$ | 8 | $\begin{aligned} & 2.4 \\ & 0.8 \\ & \pm 1 \end{aligned}$ | V min V max $\mu \mathrm{A}$ max pF typ | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=0 \text { or } \mathrm{V}_{\mathrm{DD}} \\ & \mathrm{f}=1 \mathrm{MHz} \end{aligned}$ |
| DYNAMIC CHARACTERISTICS ${ }^{2}$ <br> $t_{\text {transition }}$ | $\begin{aligned} & 250 \\ & 350 \end{aligned}$ | 450 | $\begin{aligned} & 250 \\ & 350 \end{aligned}$ | 450 | ns typ ns max | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=1 \mathrm{M} \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF} ; \\ & \mathrm{V}_{\mathrm{S} 1}=10 \mathrm{~V} / 0 \mathrm{~V}, \mathrm{~V}_{\mathrm{S} 8}=0 \mathrm{~V} / 10 \mathrm{~V} ; \\ & \text { Test Circuit } 5 \end{aligned}$ |
| topen | 25 | 10 |  | 10 | ns min | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF} ; \\ & \mathrm{V}_{\mathrm{S}}=+5 \mathrm{~V} ; \text { Test Circuit } 6 \end{aligned}$ |
| $\mathrm{t}_{\mathrm{ON}}(\mathrm{EN}, \overline{\mathrm{WR}})$ | $\begin{aligned} & 200 \\ & 300 \end{aligned}$ | 400 | $\begin{aligned} & 200 \\ & 300 \end{aligned}$ | 400 | ns typ <br> ns max | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF} ; \\ & \mathrm{V}_{\mathrm{S}}=+5 \mathrm{~V} ; \text { Test Circuit } 7 \end{aligned}$ |
| $\mathrm{t}_{\mathrm{OFF}}(\mathrm{EN}, \overline{\mathrm{RS}})$ | $\begin{aligned} & 80 \\ & 300 \end{aligned}$ | 400 | $\begin{aligned} & 80 \\ & 300 \end{aligned}$ | 400 | ns typ ns max | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF} ; \\ & \mathrm{V}_{\mathrm{S}}=+5 \mathrm{~V} ; \text { Test Circuit } 7 \end{aligned}$ |
| $\mathrm{t}_{\mathrm{w}}$, Write Pulse Width $\mathrm{t}_{\text {s }}$, Address, Enable Setup Time |  | 100 100 |  | 100 | ns min ns min |  |
| $\mathrm{t}_{\mathrm{H}}$, Address, Enable Hold Time $\mathrm{t}_{\mathrm{RS}}$, Reset Pulse Width |  | 10 100 |  | 10 | ns min ns min | $\mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}$ |
| Charge Injection | 4 |  | 4 |  | pC typ | $\mathrm{V}_{\mathrm{S}}=6 \mathrm{~V}, \mathrm{R}_{\mathrm{S}}=0 \Omega, \mathrm{C}_{\mathrm{L}}=10 \mathrm{nF}$ <br> Test Circuit 10 |
| OFF Isolation | $\begin{aligned} & -75 \\ & -60 \end{aligned}$ |  | $\begin{aligned} & -75 \\ & -60 \end{aligned}$ |  | dB typ $\mathrm{dB} \min$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}, \mathrm{f}=100 \mathrm{kHz} ; \\ & \mathrm{V}_{\mathrm{S}}=7 \mathrm{~V}_{\mathrm{RMS}}, \mathrm{~V}_{\mathrm{EN}}=0 \mathrm{~V} ; \text { Test Circuit } 11 \end{aligned}$ |
| Channel-to-Channel Crosstalk | 85 |  | 85 |  | dB typ | $\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}, \mathrm{f}=100 \mathrm{kHz}$ <br> Test Circuit 12 |
| $\mathrm{C}_{\mathrm{S}}$ (OFF) | 11 |  | 11 |  | pF typ | $\mathrm{f}=1 \mathrm{MHz}$ |
| $\mathrm{C}_{\mathrm{D}}$ (OFF) |  |  |  |  |  | $\mathrm{f}=1 \mathrm{MHz}$ |
| ADG428 | 40 |  | 40 |  | pF typ |  |
| ADG429 | 20 |  | 20 |  | pF typ |  |
| $\begin{gathered} \mathrm{C}_{\mathrm{D}}, \mathrm{C}_{\mathrm{S}}(\mathrm{ON}) \\ \text { ADG428 } \\ \text { ADG429 } \end{gathered}$ | $\begin{aligned} & 54 \\ & 34 \end{aligned}$ |  | $\begin{aligned} & 54 \\ & 34 \end{aligned}$ |  | pF typ pF typ | $\mathrm{f}=1 \mathrm{MHz}$ |
| POWER REQUIREMENTS $\mathrm{I}_{\mathrm{DD}}$ | $\begin{array}{\|l\|l} 20 \\ 100 \end{array}$ |  | $\begin{array}{\|l\|} \hline 20 \\ 100 \\ \hline \end{array}$ |  | $\mu \mathrm{A}$ typ $\mu \mathrm{A}$ max | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{EN}}=0 \mathrm{~V}$ |

[^96]
## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted.)
$\mathrm{V}_{\mathrm{DD}}$ to $\mathrm{V}_{\text {SS }}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . +44 V
$\mathrm{V}_{\mathrm{DD}}$ to GND . . . . . . . . . . . . . . . . . . . . -0.3 V to +25 V
$\mathrm{V}_{\text {ss }}$ to GND . . . . . . . . . . . . . . . . . . . . . +0.3 V to -25 V
Analog, Digital Inputs ${ }^{2} \ldots \ldots V_{s s}-2 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}+2 \mathrm{~V}$ or 30 mA , whichever occurs first
Continuous Current, S or D . . . . . . . . . . . . . . . . . . 30 mA
Peak Current, S or D . . . . . . . . . . . . . . . . . . . . . . 100 mA
(Pulsed at $1 \mathrm{~ms}, 10 \%$ Duty Cycle Max)
Operating Temperature Range
Industrial (B Version) . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Extended (T Version) . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Junction Temperature . . . . . . . . . . . . . . . . . . . . . . $+150^{\circ} \mathrm{C}$
Cerdip Package, Power Dissipation . . . . . . . . . . . . . 900 mW
$\theta_{\mathrm{JA}}$, Thermal Impedance . . . . . . . . . . . . . . . . . . $73^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature, Soldering ( 10 sec ) . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Plastic Package, Power Dissipation . . . . . . . . . . . . . 470 mW
$\theta_{\mathrm{JA}}$, Thermal Impedance . . . . . . . . . . . . . . . . . . $115^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature, Soldering ( 10 sec ) . . . . . . . . . . $+260^{\circ} \mathrm{C}$
PLCC Package, Power Dissipation . . . . . . . . . . . . . 800 mW
$\theta_{\mathrm{JA}}$, Thermal Impedance . . . . . . . . . . . . . . . . . . $90^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature, Soldering Vapor Phase ( 60 sec ) . . . . . . . . . . . . . . . . . . . . $+215^{\circ} \mathrm{C}$ Infrared (15 sec) . . . . . . . . . . . . . . . . . . . . . . $+220^{\circ} \mathrm{C}$

## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Only one absolute maximum rating may be applied at any one time.
${ }^{2}$ Overvoltages at $\mathrm{A}, \mathrm{EN}, \overline{\mathrm{WR}}, \overline{\mathrm{RS}}, \mathrm{S}$ or D will be clamped by internal diodes. Current should be limited to the maximum ratings given.

ORDERING GUIDE

| Model $^{\mathbf{1}}$ | Temperature Range | Package Option |
| :--- | :--- | :--- |
| ADG428BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-18$ |
| ADG428BP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{P}-20 \mathrm{~A}$ |
| ADG428TQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-18$ |
| ADG429BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-18$ |
| ADG429BP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{P}-20 \mathrm{~A}$ |
| ADG429TQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-18$ |

## NOTES

${ }^{1}$ To order MIL-STD-883, Class B processed parts, add /883B to T grade part numbers.
${ }^{2} \mathrm{~N}=$ Plastic DIP; $\mathrm{P}=$ Plastic Leaded Chip Carrier (PLCC); $\mathrm{Q}=$ Cerdip.
For outline information see Package Information section.

## ADG428 PIN CONFIGURATIONS



## ADG429 PIN CONFIGURATIONS

DIP


## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although these devices feature proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

TERMINOLOGY

| $\mathrm{V}_{\text {DD }}$ | Most positive power supply potential. |
| :---: | :---: |
| $\mathrm{V}_{\text {ss }}$ | Most negative power supply potential in dual supplies. In single supply applications, it may be connected to ground. |
| GND | Ground (0 V) reference. |
| $\mathrm{R}_{\text {ON }}$ | Ohmic resistance between D and S . |
| $\Delta \mathbf{R}_{\text {ON }}$ | Difference between the $\mathrm{R}_{\mathrm{ON}}$ of any two channels. |
| $\mathrm{I}_{\text {S }}$ (OFF) | Source leakage current when the switch is off. |
| $\mathrm{I}_{\mathrm{D}}$ (OFF) | Drain leakage current when the switch is off. |
| $\mathrm{I}_{\mathrm{D}}, \mathrm{I}_{\mathrm{S}}(\mathrm{ON})$ | Channel leakage current when the switch is on. |
| $\mathrm{V}_{\mathrm{D}}\left(\mathrm{V}_{\mathrm{S}}\right)$ | Analog voltage on terminals D, S. |
| $\mathrm{C}_{\text {S }}$ (OFF) | Channel input capacitance for "OFF" condition. |
| $C_{\text {D }}$ (OFF) | Channel output capacitance for "OFF" condition. |
| $C_{D}, C_{S}(O N)$ | "ON" switch capacitance. |
| $\mathrm{C}_{\text {IN }}$ | Digital input capacitance. |
| $\mathrm{t}_{\mathrm{ON}}$ (EN) | Delay time between the $50 \%$ and $90 \%$ points of the digital input and switch "ON" condition. |
| $\mathrm{t}_{\text {OFF }}(\mathrm{EN})$ | Delay time between the $50 \%$ and $90 \%$ points of the digital input and switch "OFF" condition. |
| $\mathrm{t}_{\text {TRANSITION }}$ | Delay time between the $50 \%$ and $90 \%$ points of the digital inputs and the switch "ON" condition when switching from one address state to another. |
| topen | "OFF" time measured between $80 \%$ points of both switches when switching from one address state to another. |
| $\mathrm{V}_{\text {INL }}$ | Maximum input voltage for logic " 0 ". |
| $\mathrm{V}_{\text {INH }}$ | Minimum input voltage for logic " 1 ". |
| $\mathrm{I}_{\mathbf{I N L}}\left(\mathrm{I}_{\mathrm{INH}}\right)$ | Input current of the digital input. |
| Crosstalk | A measure of unwanted signal which is coupled through from one channel to another as a result of parasitic capacitance. |
| Off Isolation | A measure of unwanted signal coupling through an "OFF" channel. |
| Charge Injection | A measure of the glitch impulse transferred from the digital input to the analog output during switching. |
| $\mathrm{I}_{\text {DD }}$ | Positive supply current. |
| $\mathrm{I}_{\text {SS }}$ | Negative supply current. |

ADG428 Truth Table

| A2 |
| :--- |
| A1 |
| A0 |
| EN |
| Latching |
| $\mathbf{X}$ |
| $\mathbf{X}$ |


| Reset |
| :--- |
| $\mathbf{X}$ | $\mathbf{X}$

Transparent Operation

| X | X | X | 0 | 0 | 1 | NONE |  |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| 0 | 0 | 0 | 1 | 0 | 1 | 1 |  |
| 0 | 0 | 1 | 1 | 0 | 1 | 2 |  |
| 0 | 1 | 0 | 1 | 0 | 1 | 3 |  |
| 0 | 1 | 1 | 1 | 0 | 1 | 4 |  |
| 1 | 0 | 0 | 1 | 0 | 1 | 5 |  |
| 1 | 0 | 1 | 1 | 0 | 1 | 6 |  |
| 1 | 1 | 0 | 1 | 0 | 1 | 7 |  |
| 1 | 1 | 1 | 1 | 0 | 1 | 8 |  |

ADG429 Truth Table

| A1 | A0 | EN | $\overline{\mathbf{W R}}$ | $\overline{\text { RS }}$ | ON SWITCH PAIR |
| :--- | :--- | :--- | :--- | :--- | :--- |

Latching

| $\mathbf{X}$ | $\mathbf{X}$ | $\mathbf{X}$ | $\Sigma$ | 1 | Maintains Previous <br> Switch Condition |
| :--- | :--- | :--- | :--- | :--- | :--- |

Reset

| $\mathbf{X}$ | $\mathbf{X}$ | $\mathbf{X}$ | $\mathbf{X}$ | $\mathbf{0}$ | NONE <br> (Latches Cleared) |
| :--- | :--- | :--- | :--- | :--- | :--- |

Transparent Operation

| X | X | 0 | 0 | 1 | NONE |
| :--- | :--- | :--- | :--- | :--- | :--- |
| 0 | 0 | 1 | 0 | 1 | 1 |
| 0 | 1 | 1 | 0 | 1 | 2 |
| 1 | 0 | 1 | 0 | 1 | 3 |
| 1 | 1 | 1 | 0 | 1 | 4 |

## TIMING DIAGRAMS



Figure 1.
Figure 1 shows the timing sequence for latching the switch address and enable inputs. The latches are level sensitive; therefore, while $\overline{\mathrm{WR}}$ is held low, the latches are transparent and the switches respond to the address and enable inputs. This input data is latched on the rising edge of $\overline{\mathrm{WR}}$.

## Typical Characteristics



Figure 3. $R_{\text {ON }}$ as a Function of $V_{D}\left(V_{S}\right)$ : Dual Supply Voltage


Figure 4. $R_{O N}$ as a Function of $V_{D}\left(V_{S}\right)$ for Different Temperatures


Figure 2.
Figure 2 shows the Reset Pulse Width, $\mathrm{t}_{\mathrm{RS}}$, and the Reset Turnoff Time, $\mathrm{t}_{\mathrm{OFF}} \overline{(\mathrm{RS})}$.
Note: All digital input signals rise and fall times are measured from $10 \%$ to $90 \%$ of 3 V . $\mathrm{tr}=\mathrm{tf}=20 \mathrm{~ns}$.


Figure 5. $R_{\text {ON }}$ as a Function of $V_{D}\left(V_{S}\right)$ : Single Supply Voltage


Figure 6. $R_{O N}$ as a Function of $V_{D}\left(V_{S}\right)$ for Different Temperatures


Figure 7. Positive Supply Current vs. Switching Frequency


Figure 8. Switching Time vs. $V_{I N}$ (Bipolar Supply)


Figure 9. Switching Time vs. Bipolar Supply


Figure 10. Negative Supply Current vs. Switching Frequency


Figure 11. Switching Time vs. $V_{I N}$ (Single Supply)


Figure 12. Switching Time vs. Single Supply


Figure 13. OFF Isolation vs. Frequency


Figure 14. Leakage Currents as a Function of $V_{D}\left(V_{S}\right)$


Figure 15. Crosstalk vs. Frequency


Figure 16. Leakage Currents as a Function of $V_{D}\left(V_{S}\right)$

## FEATURES

44 V Supply Maximum Ratings $\pm 15$ V Analog Signal Range<br>Low On Resistance (<24 $\boldsymbol{\Omega}$ )<br>Ultralow Power Dissipation ( $3.9 \mu \mathrm{~W}$ )<br>Low Leakage (<0.25 nA)<br>Fast Switching Times<br>$t_{\text {ON }}<165 \mathrm{~ns}$<br>$\mathbf{t}_{\text {OFF }}<130 \mathrm{~ns}$<br>Latch-up Proof<br>Break-Before-Make Switching Action<br>TTL/CMOS Compatible<br>Plug-in Replacement for DG411/DG412/DG413

## APPLICATIONS

## Audio and Video Switching

Automatic Test Equipment
Precision Data Acquisition
Battery Powered Systems
Sample Hold Systems
Communication Systems

## GENERAL DESCRIPTION

The ADG431, ADG432 and ADG433 are monolithic CMOS devices comprising four independently selectable switches. They are designed on an enhanced $\mathrm{LC}^{2}$ MOS, trench isolated process which provides low power dissipation yet gives high switching speed and low on resistance. Trench isolation gives all the benefits of dielectric isolation and ensures no latch up even under extreme overvoltage conditions.

The on resistance profile is very flat over the full analog input range ensuring excellent linearity and low distortion when switching audio signals. Fast switching speed coupled with high signal bandwidth also make the parts suitable for video signal switching. CMOS construction ensures ultralow power dissipation making the parts ideally suited for portable and battery powered instruments.
The ADG431, ADG432 and ADG433 contain four independent SPST switches. The ADG431 and ADG432 differ only in that the digital control logic is inverted. The ADG431 switches are turned on with a logic low on the appropriate control input, while a logic high is required for the ADG432. The ADG433 has two switches with digital control logic similar to that of the ADG431 while the logic is inverted on the other two switches.
Each switch conducts equally well in both directions when ON and has an input signal range which extends to the supplies. In the OFF condition, signal levels up to the supplies are blocked. All switches exhibit break before make switching action for use in multiplexer applications. Inherent in the design is low charge injection for minimum transients when switching the digital inputs.

## FUNCTIONAL BLOCK DIAGRAMS





SWITCHES SHOWN FOR A LOGIC "1" INPUT

## PRODUCT HIGHLIGHTS

1. Extended Signal Range

The ADG431, ADG432 and ADG433 are fabricated on an enhanced LC ${ }^{2}$ MOS, trench isolated process giving an increased signal range which extends fully to the supply rails.
2. Ultralow Power Dissipation
3. Low $\mathrm{R}_{\mathrm{ON}}$
4. Trench Isolation Guards Against Latch-up

A dielectric trench separates the $P$ and $N$ channel transistors thereby preventing latch-up even under severe overvoltage conditions.
5. Break Before Make Switching

This prevents channel shorting when the switches are configured as a multiplexer.
6. Single Supply Operation

For applications where the analog signal is unipolar, the ADG431, ADG432 and ADG433 can be operated from a single rail power supply. The parts are fully specified with a single +12 V power supply and will remain functional with single supplies as low as +5 V .

## SPECIFICATIONS ${ }^{1}$

Dual Supply $\left(\mathrm{v}_{00}=+15 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{\mathrm{SS}}=-15 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{\mathrm{L}}=+5 \mathrm{~V} \pm 10 \%, \mathrm{GNO}=\mathrm{OV}\right.$, unless otherwise noted)

\begin{tabular}{|c|c|c|c|c|c|c|}
\hline Parameter \& \[
\begin{array}{r}
\mathrm{B} \\
+25^{\circ} \mathrm{C}
\end{array}
\] \& \[
\begin{aligned}
\& \text { Version } \\
\& -40^{\circ} \mathrm{C} \text { to } \\
\& +85^{\circ} \mathrm{C}
\end{aligned}
\] \& \[
+25^{\circ} \mathrm{C}
\] \& \[
\begin{aligned}
\& \text { Version } \\
\& -55^{\circ} \mathrm{C} \text { to } \\
\& +125^{\circ} \mathrm{C}
\end{aligned}
\] \& Units \& Test Conditions/Comments \\
\hline \begin{tabular}{l}
ANALOG SWITCH \\
Analog Signal Range \(\mathrm{R}_{\mathrm{ON}}\) \\
\(\mathrm{R}_{\mathrm{ON}}\) vs. \(\mathrm{V}_{\mathrm{D}}\left(\mathrm{V}_{\mathrm{s}}\right)\) \\
\(\mathrm{R}_{\mathrm{ON}}\) Drift \\
\(\mathrm{R}_{\mathrm{ON}}\) Match
\end{tabular} \& \[
\begin{array}{|l|}
17 \\
24 \\
15 \\
0.5 \\
5
\end{array}
\] \& \[
\begin{aligned}
\& V_{D D} \text { to } V_{S S} \\
\& 26
\end{aligned}
\] \& \[
\begin{aligned}
\& 17 \\
\& 24 \\
\& 15 \\
\& 0.5 \\
\& 5
\end{aligned}
\] \& \[
V_{D D} \text { to } V_{s s}
\]
\[
27
\] \& \begin{tabular}{l}
V \\
\(\Omega\) typ \\
\(\Omega\) max \\
\% typ \\
\(\% /{ }^{\circ} \mathrm{C}\) typ \\
\% typ
\end{tabular} \& \[
\begin{aligned}
\& \mathrm{V}_{\mathrm{D}}= \pm 8.5 \mathrm{~V}, \mathrm{I}_{\mathrm{s}}=-10 \mathrm{~mA} ; \\
\& \mathrm{V}_{\mathrm{DD}}=+13.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=-13.5 \mathrm{~V}
\end{aligned}
\]
\[
\mathrm{V}_{\mathrm{D}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=-10 \mathrm{~mA}
\] \\
\hline \begin{tabular}{l}
LEAKAGE CURRENTS \\
Source OFF Leakage \(I_{S}\) (OFF) \\
Drain OFF Leakage \(I_{D}\) (OFF) \\
Channel ON Leakage \(I_{D}, I_{S}(O N)\)
\end{tabular} \& \[
\begin{aligned}
\& \pm 0.05 \\
\& \pm 0.25 \\
\& \pm 0.05 \\
\& \pm 0.25 \\
\& \pm 0.1 \\
\& \pm 0.35
\end{aligned}
\] \& \[
\begin{aligned}
\& \pm 2 \\
\& \pm 2 \\
\& \pm 2
\end{aligned}
\] \& \[
\begin{aligned}
\& \pm 0.05 \\
\& \pm 0.25 \\
\& \pm 0.05 \\
\& \pm 0.25 \\
\& \pm 0.1 \\
\& \pm 0.35
\end{aligned}
\] \& \[
\begin{aligned}
\& \pm 15 \\
\& \pm 15 \\
\& \pm 17
\end{aligned}
\] \& nA typ nA max nA typ nA max nA typ nA max \& \begin{tabular}{l}
\[
\begin{aligned}
\& \mathrm{V}_{\mathrm{DD}}=+16.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{ss}}=-16.5 \mathrm{~V} \\
\& \mathrm{~V}_{\mathrm{D}}= \pm 15.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{s}}=\mp 15.5 \mathrm{~V}
\end{aligned}
\] \\
Test Circuit 2
\[
\mathrm{V}_{\mathrm{D}}= \pm 15.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{S}}=\mp 15.5 \mathrm{~V}
\] \\
Test Circuit 2
\[
\mathrm{V}_{\mathrm{D}}=\mathrm{V}_{\mathrm{S}}= \pm 15.5 \mathrm{~V}
\] \\
Test Circuit 3
\end{tabular} \\
\hline \begin{tabular}{l}
DIGITAL INPUTS \\
Input High Voltage, \(\mathrm{V}_{\text {INH }}\) \\
Input Low Voltage, \(\mathrm{V}_{\text {INL }}\) \\
Input Current \\
\(\mathrm{I}_{\text {INL }}\) or \(\mathrm{I}_{\text {INH }}\) \\
\(\mathrm{C}_{\text {IN }}\) Digital Input Capacitance
\end{tabular} \& \[
\begin{aligned}
\& \\
\& 0.005 \\
\& 9
\end{aligned}
\] \& \begin{tabular}{l}
2.4 \\
0.8
\[
\pm 0.02
\]
\end{tabular} \& \begin{tabular}{l}
\[
0.005
\] \\
9
\end{tabular} \& \[
\begin{aligned}
\& 2.4 \\
\& 0.8 \\
\& \\
\& \pm 0.02
\end{aligned}
\] \& V min V max \(\mu \mathrm{A}\) typ \(\mu \mathrm{A}\) max pF typ \& \(\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {INL }}\) or \(\mathrm{V}_{\text {INH }}\) \\
\hline \begin{tabular}{l}
DYNAMIC CHARACTERISTICS \({ }^{2}\) \\
\(\mathrm{t}_{\mathrm{ON}}\) \\
\(t_{\text {OFF }}\) \\
Break-Before-Make Time Delay, \(\mathrm{t}_{\mathrm{D}}\) (ADG433 Only) \\
Charge Injection \\
OFF Isolation \\
Channel-to-Channel Crosstalk \\
\(\mathrm{C}_{\mathrm{s}}\) (OFF) \\
\(\mathrm{C}_{\mathrm{D}}\) (OFF) \\
\(\mathrm{C}_{\mathrm{D}}, \mathrm{C}_{\mathrm{S}}(\mathrm{ON})\)
\end{tabular} \& \[
\begin{aligned}
\& 90 \\
\& 60 \\
\& 25 \\
\& 5 \\
\& 5 \\
\& 68 \\
\& 85 \\
\& \\
\& 9 \\
\& 9 \\
\& 9 \\
\& 35
\end{aligned}
\] \& \[
\begin{aligned}
\& 165 \\
\& 130
\end{aligned}
\] \& \begin{tabular}{l}
90 \\
60 \\
25 \\
5 \\
68 \\
85 \\
9 \\
9 \\
35
\end{tabular} \& 175
145 \& \begin{tabular}{l}
ns typ ns max ns typ ns max ns typ \\
pC typ \\
dB typ \\
dB typ \\
pF typ \\
pF typ \\
pF typ
\end{tabular} \& \begin{tabular}{l}
\[
\begin{aligned}
\& \mathrm{V}_{\mathrm{DD}}=+15 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=-15 \mathrm{~V} \\
\& \mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF} ; \\
\& \mathrm{V}_{\mathrm{S}}= \pm 10 \mathrm{~V} ; \text { Test Circuit } 4 \\
\& \mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF} ; \\
\& \mathrm{V}_{\mathrm{S}}= \pm 10 \mathrm{~V} ; \text { Test Circuit } 4 \\
\& \mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF} ; \\
\& \mathrm{V}_{\mathrm{S} 1}=\mathrm{V}_{\mathrm{S} 2}=+10 \mathrm{~V} ;
\end{aligned}
\] \\
Test Circuit 5
\[
\mathrm{V}_{\mathrm{s}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{S}}=0 \Omega, \mathrm{C}_{\mathrm{L}}=10 \mathrm{nF}
\] \\
Test Circuit 6
\[
\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{f}=1 \mathrm{MHz}
\] \\
Test Circuit 7
\[
\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{f}=1 \mathrm{MHz}
\] \\
Test Circuit 8 \\
\(\mathrm{f}=1 \mathrm{MHz}\) \\
\(\mathrm{f}=1 \mathrm{MHz}\)
\[
\mathrm{f}=1 \mathrm{MHz}
\]
\end{tabular} \\
\hline \begin{tabular}{l}
POWER REQUIREMENTS
\[
\begin{aligned}
\& \mathrm{I}_{\mathrm{DD}} \\
\& \mathrm{I}_{\mathrm{SS}} \\
\& \mathrm{I}_{\mathrm{L}}
\end{aligned}
\] \\
Power Dissipation
\end{tabular} \& \[
\begin{array}{|l}
0.0001 \\
0.1 \\
0.0001 \\
0.1 \\
0.0001 \\
0.1
\end{array}
\] \& 0.2
0.2

0.2

7.7 \& $$
\begin{array}{|l}
0.0001 \\
0.1 \\
0.0001 \\
0.1 \\
0.0001 \\
0.1
\end{array}
$$ \& \[

$$
\begin{aligned}
& 0.2 \\
& 0.2 \\
& 0.2 \\
& 7.7
\end{aligned}
$$

\] \& $\mu \mathrm{A}$ typ $\mu \mathrm{A}$ max $\mu \mathrm{A}$ typ $\mu \mathrm{A}$ max $\mu \mathrm{A}$ typ $\mu \mathrm{A}$ max $\mu \mathrm{W}$ max \& \[

$$
\begin{aligned}
& \mathrm{V}_{\mathrm{DD}}=+16.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=-16.5 \mathrm{~V} \\
& \text { Digital Inputs }=0 \mathrm{~V} \text { or } 5 \mathrm{~V}
\end{aligned}
$$
\] <br>

\hline
\end{tabular}

[^97]
## ADG431/ADG432/ADG433

Single Supply $\mathrm{V}_{00}=+12 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{5 S}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=+5 \mathrm{~V} \pm 10 \%$, $\mathrm{ENO}=0 \mathrm{~V}$, unless otherwise notel)


[^98]Truth Table (ADG431/ADG432)

| ADG431 In | ADG432 In | Switch Condition |
| :--- | :--- | :--- |
| 0 | 1 | ON |
| 1 | 0 | OFF |

Truth Table (ADG433)

| Logic | Switch 1, 4 | Switch 2, 3 |
| :--- | :--- | :--- |
| 0 | OFF | ON |
| 1 | ON | OFF |

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)
$\mathrm{V}_{\mathrm{DD}}$ to $\mathrm{V}_{\mathrm{ss}}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . +44 V
$\mathrm{V}_{\mathrm{DD}}$ to GND . . . . . . . . . . . . . . . . . . . . . -0.3 V to +25 V
$\mathrm{V}_{\mathrm{ss}}$ to GND . . . . . . . . . . . . . . . . . . . . . +0.3 V to -25 V
$\mathrm{V}_{\mathrm{L}}$ to GND . . . . . . . . . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Analog, Digital Inputs ${ }^{2} \ldots \ldots V_{S s}-2 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}+2 \mathrm{~V}$ or 30 mA , whichever occurs first
Continuous Current, S or D . . . . . . . . . . . . . . . . . . 30 mA
Peak Current, S or D . . . . . . . . . . . . . . . . . . . . . . 100 mA
(Pulsed at $1 \mathrm{~ms}, 10 \%$ Duty Cycle max)
Operating Temperature Range
Industrial (B Version) . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Extended (T Version) . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Junction Temperature . . . . . . . . . . . . . . . . . . . . . . $+150^{\circ} \mathrm{C}$
Cerdip Package, Power Dissipation . . . . . . . . . . . . . 900 mW
$\theta_{\mathrm{JA}}$, Thermal Impedance . . . . . . . . . . . . . . . . . . $76^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature, Soldering (10 sec) ..... $+300^{\circ} \mathrm{C}$
Plastic Package, Power Dissipation ..... 470 mW
$\theta_{\mathrm{JA}}$, Thermal Impedance ..... $117^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature, Soldering ( 10 sec ) ..... $+260^{\circ} \mathrm{C}$
SOIC Package, Power Dissipation . ..... 600 mW
$\theta_{\mathrm{IA}}$, Thermal Impedance ..... $77^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature, Soldering
Vapor Phase ( 60 sec ) ..... $+215^{\circ} \mathrm{C}$
Infrared (15 sec) ..... $+220^{\circ} \mathrm{C}$
NOTES
${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Only one absolute maximum rating may be applied at any one time.
${ }^{2}$ Overvoltages at IN, S or D will be clamped by internal diodes. Current should be limited to the maximum ratings given.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although these devices feature proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

PIN CONFIGURATION
(DIP/SOIC)


ORDERING GUIDE

| Model $^{\mathbf{1}}$ | Temperature Range | Package Option ${ }^{2}$ |
| :--- | :--- | :--- |
| ADG431BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| ADG431BR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16 \mathrm{~A}$ |
| ADG431TQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| ADG432BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| ADG432BR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16 \mathrm{~A}$ |
| ADG432TQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| ADG433BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| ADG433BR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16 \mathrm{~A}$ |

NOTES
${ }^{1}$ To order MIL-STD-883, Class B processed parts, add /883B to T grade part numbers.
${ }^{2} \mathrm{~N}=$ Plastic DIP; $\mathrm{R}=0.15^{\prime \prime}$ Small Outline IC (SOIC); $\mathrm{Q}=$ Cerdip. For outline information see Package Information section.

## TERMINOLOGY

| $\mathrm{V}_{\mathrm{DD}}$ | Most positive power supply potential. | $\mathrm{C}_{\text {S }}$ (OFF) | "OFF" switch source capacitance. |
| :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {SS }}$ | Most negative power supply potential in dual supplies. In single supply applications, it may be connected to GND. | $\mathrm{C}_{\mathrm{D}}$ (OFF) | "OFF" switch drain capacitance. |
|  |  | $\mathrm{C}_{\mathrm{D}}, \mathrm{C}_{\mathrm{S}}(\mathrm{ON})$ | "ON" switch capacitance. |
|  |  | $\mathrm{C}_{\text {IN }}$ | Input Capacitance to ground of a digital input. |
| $\mathrm{V}_{\mathrm{L}}$ | Logic power supply ( +5 V ). | $\mathrm{t}_{\mathrm{ON}}$ | Delay between applying the digital control input |
| GND | Ground ( 0 V ) reference. | ON | and the output switching on. |
| S | Source terminal. May be an input or output. | $\mathrm{t}_{\mathrm{OFF}}$ | Delay between applying the digital control input |
| D | Drain terminal. May be an input or output. |  | and the output switching off. |
| IN | Logic control input. | $\mathrm{t}_{\mathrm{D}}$ | "OFF" time or "ON" time measured between the |
| $\mathrm{R}_{\mathrm{ON}}$ | Ohmic resistance between D and S. |  | $90 \%$ points of both switches, when switching |
| $\mathrm{R}_{\mathrm{ON}}$ vs. $\mathrm{V}_{\mathrm{D}}\left(\mathrm{V}_{\mathrm{S}}\right)$ | The variation in $\mathrm{R}_{\mathrm{ON}}$ due to a change in the analog input voltage with a constant load current. | Crosstalk | from one address state to another. <br> A measure of unwanted signal which is coupled |
| $\mathrm{R}_{\text {ON }}$ Drift | Change in $\mathrm{R}_{\mathrm{ON}}$ vs. temperature. |  | through from one channel to another as a result |
| $\mathrm{R}_{\text {ON }}$ Match | Difference between the $\mathrm{R}_{\mathrm{ON}}$ of any two switches. |  | of parasitic capacitance. <br> A measure of unwanted signal coupling through |
| $\mathrm{I}_{\text {S }}$ (OFF) | Source leakage current with the switch "OFF." | Off Isolation | A measure of unwanted signal coupling through an "OFF" switch. |
| $\mathrm{I}_{\mathrm{D}}$ (OFF) | Drain leakage current with the switch "OFF." |  | A measure of the glitch impulse transferred from |
| $\mathrm{I}_{\mathrm{D}}, \mathrm{I}_{\mathrm{S}}(\mathrm{ON})$ | Channel leakage current with the switch "ON." | Charge <br> Injection | A measure of the glitch impulse transferred from the digital input to the analog output during |
| $\mathrm{V}_{\mathrm{D}}\left(\mathrm{V}_{\mathrm{S}}\right)$ | Analog voltage on terminals D, S. |  | switching. |

## ADG431/ADG432/ADG433

## Typical Performance Graphs



Figure 1. On Resistance as a Function of $V_{D}\left(V_{s}\right)$ Dual Supplies


Figure 2. On Resistance as a Function of $V_{D}\left(V_{S}\right)$ for Different Temperatures


Figure 3. Leakage Currents as a Function of Temperature


Figure 4. On Resistance as a Function of $V_{D}\left(V_{S}\right)$ Single Supply


Figure 5. Supply Current vs. Input Switching Frequency


Figure 6. Leakage Currents as a Function of $V_{D}\left(V_{S}\right)$


Figure 7. Off Isolation vs. Frequency


Figure 8. Crosstalk vs. Frequency

## TRENCH ISOLATION

In the ADG431, ADG432 and ADG433, an insulating oxide layer (trench) is placed between the NMOS and the PMOS transistors of each CMOS switch. Parasitic junctions, which occur between the transistors in Junction Isolated switches, are eliminated, the result being a completely latch-up proof switch.
In Junction Isolation, the N and P wells of the PMOS and NMOS transistors form a diode which is reverse-biased under normal operation. However, during overvoltage conditions, this diode becomes forward biased. A Silicon-Controlled Rectifier (SCR) type circuit is formed by the two transistors causing a significant amplification of the current which, in turn, leads to latch-up. With Trench Isolation, this diode is removed, the result being a latch-up proof switch.
Trench Isolation also leads to lower leakage currents. The ADG431, ADG432 and ADG433 have a leakage current of 0.25 nA as compared with a leakage current of several nanoamps in non-Trench Isolated switches. Leakage current is an important parameter in sample-and-hold circuits, this current being responsible for the discharge of the holding capacitor with time causing droop. The ADG431/ADG432/ADG433's low leakage current, along with its fast switching speeds, make it suitable for fast and accurate sample-and-hold circuits.


SUBSTRATE (BACKGATE)

## APPLICATION

Figure 10 illustrates a precise, fast sample-and-hold circuit. An AD845 is used as the input buffer while the output operational amplifier is an AD711. During the track mode, SW1 is closed and the output $\mathrm{V}_{\text {OUT }}$ follows the input signal $\mathrm{V}_{\text {IN }}$. In the hold mode, SW1 is opened and the signal is held by the hold capacitor $\mathrm{C}_{\mathrm{H}}$.
Due to switch and capacitor leakage, the voltage on the hold capacitor will decrease with time. The ADG431/ADG432/ ADG433 minimizes this droop due to its low leakage specifications. The droop rate is further minimized by the use of a polystyrene hold capacitor. The droop rate for the circuit shown is typically $30 \mu \mathrm{~V} / \mu \mathrm{s}$.
A second switch SW2, which operates in parallel with SW1, is included in this circuit to reduce pedestal error. Since both switches will be at the same potential, they will have a differential effect on the op amp AD711 which will minimize charge injection effects. Pedestal error is also reduced by the compensation network $\mathrm{R}_{\mathrm{C}}$ and $\mathrm{C}_{\mathrm{C}}$. This compensation network also reduces the hold time glitch while optimizing the acquisition time. Using the illustrated op amps and component values, the pedestal error has a maximum value of 5 mV over the $\pm 10 \mathrm{~V}$ input range. Both the acquisition and settling times are 850 ns .


Figure 10. Fast, Accurate Sample-and-Hold

## ADG431/ADG432/ADG433

## Test Circuits



Test Circuit 1. On Resistance


Test Circuit 2. Off Leakage


Test Circuit 3. On Leakage


Test Circuit 4. Switching Times


Test Circuit 5. Break-Before-Make Time Delay


Test Circuit 6. Charge Injection


Test Circuit 7. Off Isolation


Test Circuit 8. Channel-to-Channel Crosstalk

## FEATURES

44 V Supply Maximum Ratings
$\mathbf{V}_{\text {ss }}$ to $\mathbf{V}_{\text {DD }}$ Analog Signal Range
Low On Resistance ( $<70 \Omega$ )
Low $\Delta R_{\text {ON }}(9 \Omega$ max)
Low Row Match ( $3 \Omega$ max)
Low Power Dissipation
Fast Switching Times
$t_{\text {ON }}<110$ ns
$t_{\text {off }}<\mathbf{6 0}$ ns
Low Leakage Currents ( 3 nA max)
Low Charge Injection ( 6 pC max)
Break-Before-Make Switching Action
Latch-Up Proof
Plug-In Upgrade for
DG201A/ADG201A, DG202A/ADG202A,
DG211/ADG211A
Plug in Replacement for DG441/DG442/DG444

## APPLICATIONS <br> Audio and Video Switching <br> Automatic Test Equipment <br> Precision Data Acquisition <br> Battery Powered Systems <br> Sample Hold Systems <br> Communication Systems

## GENERAL DESCRIPTION

The ADG441, ADG442 and ADG444 are monolithic CMOS devices comprising four independently selectable switches. They are designed on an enhanced LC $^{2}$ MOS process that provides low power dissipation yet gives high switching speed and low on resistance.

The on resistance profile is very flat over the full analog input range ensuring good linearity and low distortion when switching audio signals. High switching speed also makes the parts suitable for video signal switching. CMOS construction ensures ultralow power dissipation making the parts ideally suited for portable and battery powered instruments.
The ADG441, ADG442 and ADG444 contain four independent SPST switches. Each switch of the ADG441 and ADG444 turns on when a logic low is applied to the appropriate control input. The ADG442 switches are turned on with a logic high on the appropriate control input. The ADG441 and ADG444 switches differ in that the ADG444 requires a 5 V logic power supply which is applied to the $V_{L}$ pin. The ADG441 and ADG442 do not have a $\mathrm{V}_{\mathrm{L}}$ pin, the logic power supply being generated internally by an on-chip voltage generator.

## FUNCTIONAL BLOCK DIAGRAMS



SWITCHES SHOWN FOR A LOGIC "1" INPUT

Each switch conducts equally well in both directions when ON and has an input signal range that extends to the power supplies. In the OFF condition, signal levels up to the supplies are blocked. All switches exhibit break-before-make switching action for use in multiplexer applications. Inherent in the design is low charge injection for minimum transients when switching the digital inputs.

## PRODUCT HIGHLIGHTS

1. Extended Signal Range

The ADG441/ADG442/ADG444 are fabricated on an enhanced LC ${ }^{2}$ MOS, trench-isolated process, giving an increased signal range that extends to the supply rails.
2. Low Power Dissipation
3. Low $\mathrm{R}_{\mathrm{ON}}$
4. Trench Isolation Guards Against Latch Up

A dielectric trench separates the P and N channel transistors thereby preventing latch up even under severe overvoltage conditions.
5. Break-Before-Make Switching

This prevents channel shorting when the switches are configured as a multiplexer.
6. Single Supply Operation

For applications where the analog signal is unipolar, the ADG441/ADG442/ADG444 can be operated from a single rail power supply. The parts are fully specified with a single +12 V power supply.

[^99]Dual Supply $\mathrm{V}_{D D}=+15 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{S S}=-15 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{\mathrm{L}}=+5 \mathrm{~V} \pm 10 \%$ (ADG444), GND $=0 \mathrm{~V}$, unless otherwise noted)


[^100]Singe Supply $V_{D D}=+12 V \pm 10 \%, V_{S S}=0 V, V_{L}=+5 V \pm 10 \%$ (ADG444), GND $=0 V$, unless otherwise noted)

| Parameter | $\begin{array}{r} \mathrm{B} \\ +25^{\circ} \mathrm{C} \\ \hline \end{array}$ | $\begin{aligned} & \text { sion } \\ & -40^{\circ} \mathrm{C} \text { to } \\ & +85^{\circ} \mathrm{C} \end{aligned}$ $+85^{\circ} \mathrm{C}$ | $\begin{array}{r} \mathrm{TV} \\ +25^{\circ} \mathrm{C} \end{array}$ | $\begin{aligned} & \text { sion } \\ & -55^{\circ} \mathrm{C} \text { to } \\ & +125^{\circ} \mathrm{C} \\ & \hline \end{aligned}$ | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ANALOG SWITCH Analog Signal Range $\mathrm{R}_{\mathrm{ON}}$ $\Delta \mathrm{R}_{\mathrm{ON}}$ $\mathrm{R}_{\mathrm{ON}}$ Match | $\begin{aligned} & 70 \\ & 110 \end{aligned}$ | 0 to $\mathrm{V}_{\mathrm{DD}}$ 130 4 9 1 3 | $\begin{aligned} & 70 \\ & 110 \end{aligned}$ | $\begin{aligned} & 0 \text { to } V_{D D} \\ & 130 \\ & 4 \\ & 9 \\ & 1 \\ & 3 \end{aligned}$ | V <br> $\Omega$ typ $\Omega$ max $\Omega$ typ $\Omega$ max $\Omega$ typ $\Omega$ max | $\begin{aligned} & \mathrm{V}_{\mathrm{D}}=+3 \mathrm{~V},+8 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=-10 \mathrm{~mA} ; \\ & \mathrm{V}_{\mathrm{DD}}=+10.8 \mathrm{~V} \\ & +3 \mathrm{~V} \leq \mathrm{V}_{\mathrm{D}} \leq+8 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{D}}=6 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=-10 \mathrm{~mA} \end{aligned}$ |
| LEAKAGE CURRENT <br> Source OFF Leakage $\mathrm{I}_{\mathrm{S}}$ (OFF) <br> Drain OFF Leakage $I_{D}(O F F)$ <br> Channel ON Leakage $\mathrm{I}_{\mathrm{D}}, \mathrm{I}_{\mathrm{S}}(\mathrm{ON})$ | $\begin{aligned} & \pm 0.01 \\ & \pm 0.5 \\ & \pm 0.01 \\ & \pm 0.5 \\ & \pm 0.08 \\ & \pm 0.5 \end{aligned}$ | $\begin{aligned} & \pm 3 \\ & \pm 3 \\ & \pm 3 \end{aligned}$ | $\begin{aligned} & \pm 0.01 \\ & \pm 0.5 \\ & \pm 0.01 \\ & \pm 0.5 \\ & \pm 0.08 \\ & \pm 0.5 \end{aligned}$ | $\begin{aligned} & \pm 20 \\ & \pm 20 \\ & \pm 40 \end{aligned}$ | nA typ nA max nA typ nA max nA typ nA max | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=+13.2 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{D}}=12.2 \mathrm{~V} / 1 \mathrm{~V}, \mathrm{~V}_{\mathrm{S}}=1 \mathrm{~V} / 12.2 \mathrm{~V} \text {; } \\ & \text { Test Circuit } 2 \\ & \mathrm{~V}_{\mathrm{D}}=12.2 \mathrm{~V} / 1 \mathrm{~V}, \mathrm{~V}_{\mathrm{S}}=1 \mathrm{~V} / 12.2 \mathrm{~V} ; \\ & \text { Test Circuit } 2 \\ & \mathrm{~V}_{\mathrm{S}}=\mathrm{V}_{\mathrm{D}}=12.2 \mathrm{~V} / 1 \mathrm{~V} ; \\ & \text { Test Circuit } 3 \end{aligned}$ |
| DIGITAL INPUTS <br> Input High Voltage, $\mathrm{V}_{\text {INH }}$ Input Low Voltage, $\mathrm{V}_{\text {INL }}$ Input Current $\mathrm{I}_{\text {INL }}$ or $\mathrm{I}_{\text {INH }}$ |  | $\begin{aligned} & 2.4 \\ & 0.8 \\ & +0.00001 \\ & \pm 0.5 \end{aligned}$ |  | $\begin{aligned} & 2.4 \\ & 0.8 \\ & \pm 0.00001 \\ & \pm 0.5 \end{aligned}$ | $V_{\text {min }}$ <br> $V_{\text {max }}$ <br> $\mu \mathrm{A}$ typ <br> $\mu \mathrm{A}$ max | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{INL}} \text { or } \mathrm{V}_{\mathrm{INH}}$ |
| DYNAMIC CHARACTERISTICS ${ }^{2}$ <br> $\mathrm{t}_{\mathrm{ON}}$ <br> $\mathrm{t}_{\mathrm{OFF}}$ <br> topen Charge Injection <br> OFF Isolation <br> Channel-to-Channel Crosstalk <br> $\mathrm{C}_{\mathrm{S}}$ (OFF) <br> $\mathrm{C}_{\mathrm{D}}$ (OFF) <br> $\mathrm{C}_{\mathrm{D}}, \mathrm{C}_{\mathrm{S}}(\mathrm{ON})$ | 105 150 40 60 50 2 6 60 100 7 10 16 | 220 100 | $\begin{aligned} & 105 \\ & 150 \\ & 40 \\ & 60 \\ & 50 \\ & 2 \\ & 6 \\ & 60 \\ & 60 \\ & 100 \\ & 7 \\ & 10 \\ & 16 \end{aligned}$ | 220 100 | ns typ ns max ns typ ns max ns typ pC typ pC max dB typ <br> dB typ <br> pF typ pF typ pF typ |  |
| POWER REQUIREMENTS <br> $I_{D D}$ <br> ADG441/ADG442 <br> ADG444 <br> $\mathrm{I}_{\mathrm{L}}$ (ADG444 Only) | $\begin{aligned} & 0.001 \\ & 1 \\ & 0.001 \\ & 1 \end{aligned}$ | 80 2.5 2.5 | $\begin{aligned} & 0.001 \\ & 1 \\ & 0.001 \\ & 1 \end{aligned}$ | $\begin{aligned} & 80 \\ & 2.5 \\ & 2.5 \end{aligned}$ | $\mu \mathrm{A} \max$ $\mu \mathrm{A}$ typ $\mu \mathrm{A}$ max $\mu \mathrm{A}$ typ $\mu \mathrm{A}$ max | $V_{\mathrm{DD}}=+13.2 \mathrm{~V}$ <br> Digital Inputs $=0 \mathrm{~V}$ or 5 V . $\mathrm{V}_{\mathrm{L}}=+5.5 \mathrm{~V}$ |

## NOTES

${ }^{1}$ Temperature ranges are as follows: B Versions: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; T Versions: $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
${ }^{2}$ Guaranteed by design, not subject to production test.
Specifications subject to change without notice.
Table I. Truth Table

| ADG441/ADG444 <br> IN | ADG442 <br> IN | Switch <br> Condition |
| :--- | :--- | :--- |
| 0 | 1 | ON |
| 1 | 0 | OFF |


| Model $^{1}$ | Temperature Range | Package Option |
| :--- | :--- | :--- |
| ADG441BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| ADG441BR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16 \mathrm{~A}$ |
| ADG441TQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| ADG442BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| ADG442BR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | R-16A |
| ADG444BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| ADG444BR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | R-16A |

[^101]| ABSOLUTE MAXIMUM RATINGS ${ }^{1}$ | TERMINOLOGY |  |
| :---: | :---: | :---: |
| ( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted) |  |  |
| $\mathrm{V}_{\mathrm{DD}}$ to $\mathrm{V}_{\text {SS }}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . +44 V | $V_{\text {DD }}$ | Most Positive Power Supply Potential. |
| $\mathrm{V}_{\mathrm{DD}}$ to GND . . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to +25 V | $\mathrm{V}_{\text {SS }}$ | Most Negative P |
| $\mathrm{V}_{\text {ss }}$ to GND . . . . . . . . . . . . . . . . . . . . . . . . . +0.3 V to -25 V |  | supplies. In single supply applications, it may be |
| $\mathrm{V}_{\mathrm{L}}$ to GND . . . . . . . . . . . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |  | connected to ground. |
| Analog, Digital Inputs ${ }^{2} \ldots \ldots \ldots \ldots V_{s s}-2 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}+2 \mathrm{~V}$ | $\mathrm{V}_{\mathrm{L}}$ | Logic Power Supply ( +5 V ). |
| Continuous Current, S or D or 30 mA , Whichever Occurs First | GND | Ground (0 V) Reference. |
| Continuous Current, Peak Current, S or D | S | Source Terminal. May be an input or output. |
| (Pulsed at $1 \mathrm{~ms}, 10 \%$ Duty Cycle Max) | D | Drain Terminal. May be an input or output. |
| Operating Temperature Range | IN | Logic Control Input. |
| Industrial (B Version) . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}_{\mathrm{ON}}$ | Ohmic resistance between D and S . |
| Extended (T Version) . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{R}_{\mathrm{ON}} \text { Match }$ | Difference between the $\mathrm{R}_{\mathrm{ON}}$ of any two channels. |
| Storage Temperature Range $\ldots \ldots \ldots \ldots .65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{S}}(\mathrm{OFF})$ | Source leakage current with the switch "OFF." |
| Junction Temperature . . . . . . . . . . . . . . . . . . . $+150^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{D}}$ (OFF) |  |
| Cerdip Package, Power Dissipation . . . . . . . . . . . . . 900 mW | $\mathrm{I}_{\mathrm{D}}$ (OFF) | Drain leakage current with the switch "OFF." |
|  | $\mathrm{I}_{\mathrm{D}}, \mathrm{I}_{\mathrm{S}}(\mathrm{ON})$ | Channel leakage current with the switch "ON." |
| Lead Temperature, Soldering (10 sec) . . . . . . . . . . . . $+300^{\circ} \mathrm{C}$ | $\mathrm{V}_{\mathrm{D}}\left(\mathrm{V}_{\mathrm{S}}\right)$ | Analog voltage on terminals D, S. |
| Plastic Package, Power Dissipation . . . . . . . . . . . . . 470 mW | $\mathrm{C}_{\mathrm{S}}$ (OFF) | "OFF" Switch Source Capacitance. |
| $\theta_{\text {JA }}$, Thermal Impedance . . . . . . . . . . . . . . . . . . . . $1777^{\circ} \mathrm{C} / \mathrm{W}$ | $\mathrm{C}_{\mathrm{D}}$ (OFF) | "OFF" Switch Drain Capacitance. |
| Lead Temperature, Soldering (10 sec) . . . . . . . . . . $+260^{\circ} \mathrm{C}$ | $\mathrm{C}_{\mathrm{D}}, \mathrm{C}_{S}(\mathrm{ON})$ | "ON" Switch Capacitance. |
| SOIC Package, Power Dissipation . . . . . . . . . . . . . . 600 mW | $\mathrm{C}_{\mathrm{D}}, \mathrm{C}_{5}(\mathrm{ON})$ |  |
| $\theta_{\mathrm{J}}$, Thermal Impedance $. . . . . . . . . . . . . . . . . . . . . . . . .77^{\circ} \mathrm{C} / \mathrm{W}$ | $\mathrm{t}_{\mathrm{ON}}$ | Delay between applying the digital control input and the output switching on. |
|  |  |  |
| Vapor Phase ( 60 sec ) . . . . . . . . . . . . . . . . . . . . . . . . . $+215^{\circ} \mathrm{C}$ <br> Infrared (15 sec) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $+220^{\circ} \mathrm{C}$ | $\mathrm{t}_{\text {OFF }}$ | Delay between applying the digital control input and the output switching off. |
| NOTES <br> ${ }^{1}$ Stresses above those listed under | $\mathrm{t}_{\text {OPEN }}$ | Break-Before-Make Delay when switches are configured as a multiplexer. |
| permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute | Crosstalk | A measure of unwanted signal which is coupled through from one channel to another as a result of parasitic capacitance. |
| one absolute maximum rating may be applied at any one time. <br> ${ }^{2}$ Overvoltages at IN, S or D will be clamped by internal diodes. Current should be | Off Isolation | A measure of unwanted signal coupling through an "OFF" switch. |
| limited to the maximum ratings given. | Charge <br> Injection | A measure of the glitch impulse transferred from the digital input to the analog output during switching. |

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although these devices feature proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

## ADG441/ADG442 PIN CONFIGURATION (DIP/SOIC)



## ADG444 PIN CONFIGURATION (DIP/SOIC)

## ADG441/ADG442/ADG444

## TRENCH ISOLATION

In the ADG441, ADG442 and ADG444, an insulating oxide layer (trench) is placed between the NMOS and the PMOS transistors of each CMOS switch. Parasitic junctions, which occur between the transistors in junction isolated switches, are eliminated, the result being a completely latch-up proof switch.
In junction isolation, the N and P wells of the PMOS and NMOS transistors form a diode that is reverse-biased under normal operation. However, during overvoltage conditions, this diode becomes forward biased. A silicon-controlled rectifier (SCR) type circuit is formed by the two transistors causing a significant amplification of the current which, in turn, leads to latch up. With trench isolation, this diode is removed, the result being a latch-up proof switch.

Trench isolation also leads to lower leakage currents. The ADG441, ADG442 and ADG444 have a leakage current of 0.5 nA as compared with a leakage current of several nanoamperes in non-trench isolated switches. Leakage current is an important parameter in sample-and-hold circuits, this current being responsible for the discharge of the holding capacitor with time causing droop. The ADG441/ADG442/ADG444's low leakage current, along with its fast switching speeds, make it suitable for fast and accurate sample-and-hold circuits.


Figure 1. Trench Isolation

## Typical Performance Characteristics



Figure 2. $R_{O N}$ as a Function of $V_{D}\left(V_{S}\right)$ : Dual Supply


Figure 3. $R_{O N}$ as a Function of $V_{D}\left(V_{s}\right)$ : Single Supply


Figure 4. $R_{O N}$ as a Function of $V_{D}\left(V_{S}\right)$ for Different Temperatures


Figure 5. Leakage Currents as a Function of $V_{S}\left(V_{D}\right)$


Figure 6. Crosstalk and Off Isolation vs. Frequency


Figure 7. R $R_{O N}$ as a Function of $V_{D}\left(V_{S}\right)$ for Different Temperatures


Figure 8. Leakage Currents as a Function of $V_{S}\left(V_{D}\right)$


Figure 9. Charge Injection vs. Source Voltage

## FEATURES

44V Supply Maximum Rating
$\mathbf{V}_{\text {Ss }}$ to $\mathbf{V}_{\text {DD }}$ Analog Signal Range
Single/Dual Supply Specifications
Wide Supply Ranges ( 10.8 V to 16.5 V )
Extended Plastic Temperature Range $\left(-40^{\circ} \mathrm{C}\right.$ to $\left.+85^{\circ} \mathrm{C}\right)$
Low Power Dissipation (28mW max)
Low Leakage (20pA typ)
Available in 16-Lead DIP/SOIC and 20-Lead PLCC/LCCC Packages
Superior Alternative to:
DG508A, HI-508
DG509A, HI-509

## GENERAL DESCRIPTION

The ADG508A and ADG509A are CMOS monolithic analog multiplexers with 8 channels and dual 4 channels respectively. The ADG508A switches one of 8 inputs to a common output depending on the state of three binary addresses and an enable input. The ADG509A switches one of 4 differential inputs to a common differential output depending on the state of two binary addresses and an enable input. Both devices have TTL and 5V CMOS logic compatible digital inputs.
The ADG508A and ADG509A are designed on an enhanced LC $^{2}$ MOS process which gives an increased signal capability of $\mathrm{V}_{\mathrm{SS}}$ to $\mathrm{V}_{\mathrm{DD}}$ and enables operation over a wide range of supply voltages. The devices can comfortably operate anywhere in the 10.8 V to 16.5 V single or dual supply range. These multiplexers also feature high switching speeds and low $\mathrm{R}_{\mathrm{ON}}$.

## PRODUCT HIGHLIGHTS

1. Single/Dual Supply Specifications with a Wide Tolerance: The devices are specified in the 10.8 V to 16.5 V range for both single and dual supplies.
2. Extended Signal Range:

The enhanced $L^{2}$ MOS processing results in a high breakdown and an increased analog signal range of $V_{S s}$ to $V_{D D}$.
3. Break-Before-Make Switching:

Switches are guaranteed break-before-make so that input signals are protected against momentary shorting.
4. Low Leakage:

Leakage currents in the range of 20 pA make these multiplexers suitable for high precision circuits.

FUNCTIONAL BLOCK DIAGRAMS


## ORDERING GUIDE

|  | Temperature <br> Range | Package <br> Option |
| :--- | :--- | :--- |
| ADG508AKN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| ADG508AKR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16 \mathrm{~A}$ |
| ADG508AKP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{P}-20 \mathrm{~A}$ |
| ADG508ABQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| ADG508ATQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| ADG508ATE | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{E}-20 \mathrm{~A}$ |
| ADG509AKN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| ADG509AKR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16 \mathrm{~A}$ |
| ADG509AKP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{P}-20 \mathrm{~A}$ |
| ADG509ABQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| ADG509ATQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| ADG509ATE | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{E}-20 \mathrm{~A}$ |

## NOTES

${ }^{1}$ To order MIL-STD-883, Class B processed parts, add /883B to part number. See Analog Devices Military Products Databook (1990) for military data sheet.
${ }^{2} \mathrm{E}=$ Leadless Ceramic Chip Carrier (LCCC); $\mathrm{N}=$ Plastic DIP; P = Plastic Leaded Chip Carrier (PLCC); Q = Cerdip; $\mathbf{R}=0.15^{\prime \prime}$ Small Outline IC (SOIC). For outline information see Package Information section.

## SPECIFICATIONS

DUAL SUPPLY ${ }_{\left(V_{00}\right.}=+10.8 \mathrm{v}$ to $+16.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{ss}}=-10.8 \mathrm{vto}-16.5 \mathrm{~V}$ unless otherwise noted.)

| Parameter | ADG508A <br> ADG509A <br> K Version |  | ADG508A <br> ADG509A <br> B Version |  | ADG508A <br> ADG509A <br> TVersion |  | Units | Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | $+25^{\circ} \mathrm{C}$ | $\begin{aligned} & -40^{\circ} \mathrm{Cto} \\ & +85^{\circ} \mathrm{C} \\ & \hline \end{aligned}$ | $+25^{\circ} \mathrm{C}$ | $\begin{aligned} & -40^{\circ} \mathrm{C} \text { to } \\ & +85^{\circ} \mathrm{C} \end{aligned}$ | $+25^{\circ} \mathrm{C}$ | $\begin{aligned} & -55^{\circ} \mathrm{C} \text { to } \\ & +125^{\circ} \mathrm{C} \\ & \hline \end{aligned}$ |  |  |
| ANALOG SWITCH Analog Signal Range | $\begin{aligned} & \mathbf{v}_{\text {ss }} \\ & \mathbf{v}_{\mathrm{DD}} \end{aligned}$ | $\begin{aligned} & \mathbf{V}_{\mathrm{ss}} \\ & \mathbf{V}_{\mathrm{DD}} \end{aligned}$ | $\begin{aligned} & \mathbf{V}_{\mathbf{s s}} \\ & \mathbf{V}_{\mathrm{DD}} \end{aligned}$ | $\begin{aligned} & \mathbf{V}_{\mathbf{s s}} \\ & \mathbf{V}_{\mathbf{D D}} \end{aligned}$ | $\begin{aligned} & \mathbf{V}_{\mathbf{s s}} \\ & \mathbf{V}_{\mathrm{DD}} \end{aligned}$ | $\begin{aligned} & \mathbf{v}_{\mathbf{s s}} \\ & \mathbf{v}_{\mathbf{D D}} \end{aligned}$ | $V_{\text {min }}$ $V_{\text {max }}$ |  |
| Ron | $\begin{array}{\|l\|} 280 \\ 450 \\ 300 \end{array}$ | 600 400 | $\begin{aligned} & 280 \\ & 450 \\ & 300 \end{aligned}$ | $\begin{aligned} & 600 \\ & 400 \end{aligned}$ | $\begin{aligned} & 280 \\ & 450 \\ & 300 \end{aligned}$ | 600 400 | $\Omega$ typ <br> $\Omega_{\text {max }}$ <br> $\Omega_{\text {max }}$ <br> $\Omega_{\text {max }}$ | $\begin{aligned} & -10 \mathrm{~V} \leqslant \mathrm{~V}_{\mathrm{S}} \leqslant+10 \mathrm{~V}, \mathrm{I}_{\mathrm{DS}}=1 \mathrm{~mA} ; \text { Test Circuit } \\ & \mathrm{V}_{\mathrm{DD}}=15 \mathrm{~V}( \pm 10 \%), \mathrm{V}_{\mathrm{ss}}=-15 \mathrm{~V}( \pm 10 \%) \\ & \mathrm{V}_{\mathrm{DD}}=15 \mathrm{~V}( \pm 5 \%), \mathrm{V}_{\mathrm{ss}}=-15 \mathrm{~V}( \pm 5 \%) \end{aligned}$ |
| $\mathrm{R}_{\mathrm{ON}}$ Drift <br> $\mathrm{R}_{\mathrm{ON}}$ Match | 0.6 5 |  | 0.6 5 |  | $0.6$ |  | $\begin{aligned} & \text { \%/Ttyp } \\ & \text { \%typ } \end{aligned}$ | $\begin{aligned} & V_{s}=0, I_{D S}=1 \mathrm{~mA} \\ & -10 V \leqslant V_{s} \leqslant+10 \mathrm{~V}, I_{D S}=1 \mathrm{~mA} \end{aligned}$ |
| $\mathrm{I}_{\mathbf{S}}$ (OFF), Off Input Leakage | $\begin{array}{l\|l} 0.02 \\ 1 \end{array}$ | 50 | $0.02$ | 50 | $0.02$ | 50 | nA typ <br> $n A$ max | $\mathrm{V} 1= \pm 10 \mathrm{~V}, \mathrm{~V} 2=\mp 10 \mathrm{~V}$; Test Circuit 2 |
| $\begin{aligned} & \mathrm{I}_{\mathrm{D}}(\text { OFF), Off Output Leakage } \\ & \text { ADG508A } \\ & \text { ADG509A } \end{aligned}$ | $\begin{aligned} & 0.04 \\ & 1 \\ & 1 \end{aligned}$ | 100 50 | $\begin{aligned} & 0.04 \\ & 1 \\ & 1 \end{aligned}$ | 100 50 | $\begin{aligned} & 0.04 \\ & 1 \\ & 1 \end{aligned}$ | 100 50 | nA typ <br> nA max <br> $n A$ max | $\mathrm{V} 1= \pm 10 \mathrm{~V}, \mathrm{~V} 2=\mp 10 \mathrm{~V}$; Test Circuit 3 |
| $\begin{aligned} & \mathrm{I}_{\mathrm{D}}(\mathrm{ON}), \text { On Channel Leakage } \\ & \text { ADG508A } \\ & \text { ADG509A } \end{aligned}$ | $\begin{array}{\|l} 0.04 \\ 1 \\ 1 \end{array}$ | 100 50 | $\begin{aligned} & 0.04 \\ & 1 \\ & 1 \end{aligned}$ | 100 50 | $\begin{aligned} & 0.04 \\ & 1 \\ & 1 \end{aligned}$ | 100 50 | nA typ $n A$ max $n A$ max | $\mathrm{V} 1=\mathrm{V} 2= \pm 10 \mathrm{~V}$; Test Circuit 4 |
| I $_{\text {DIFF }}$, Differential Off Output Leakage (ADG509A only) |  | 25 |  | 25 |  | 25 | $n A$ max | $\mathrm{V} 1= \pm 10 \mathrm{~V}, \mathrm{~V} 2=\mp 10 \mathrm{~V}$; Test Circuit 5 |
| DIGITALCONTROL <br> $\mathbf{V}_{\text {INH }}$, Input High Voltage <br> $\mathrm{V}_{\text {INL }}$, Input Low Voltage <br> $\mathrm{I}_{\text {INL }}$ or $\mathrm{I}_{\text {INH }}$ <br> $\mathrm{C}_{\text {IN }}$ Digital Input Capacitance | 8 | $\begin{aligned} & 2.4 \\ & 0.8 \\ & 1 \end{aligned}$ | 8 | $\begin{aligned} & 2.4 \\ & 0.8 \\ & 1 \end{aligned}$ | 8 | $\begin{aligned} & 2.4 \\ & 0.8 \\ & 1 \end{aligned}$ | $V_{\text {min }}$ <br> V max <br> $\mu \mathrm{A}$ max <br> pF max | $\mathrm{V}_{\text {IN }}=0$ to $\mathrm{V}_{\text {DD }}$ |
| DYNAMICCHARACTERISTICS <br> $t_{\text {transition }}{ }^{1}$ | $\begin{aligned} & 200 \\ & 300 \end{aligned}$ | 400 | $\begin{aligned} & 200 \\ & 300 \end{aligned}$ | 400 | $\begin{aligned} & 200 \\ & 300 \end{aligned}$ | 400 | nstyp ns max | $\mathrm{V} 1= \pm 10 \mathrm{~V}, \mathrm{~V} 2=\mp 10 \mathrm{~V}$; Test Circuit 6 |
| topen ${ }^{1}$ | $\begin{aligned} & 50 \\ & 25 \end{aligned}$ | 10 | $\begin{aligned} & 50 \\ & 25 \end{aligned}$ | 10 | $\begin{aligned} & 50 \\ & 25 \end{aligned}$ | 10 | ns typ ns min | Test Circuit 7 |
| ton $(\mathrm{EN})^{1}$ | $\begin{aligned} & 200 \\ & 300 \end{aligned}$ | 400 | $\begin{aligned} & 200 \\ & 300 \end{aligned}$ | 400 | $\begin{aligned} & 200 \\ & 300 \end{aligned}$ | 400 | ns typ ns max | Test Circuit 8 |
| $\mathrm{tofr}^{(E N)}{ }^{1}$ | $\begin{aligned} & 200 \\ & 300 \end{aligned}$ | 400 | $\begin{aligned} & 200 \\ & 300 \end{aligned}$ | 400 | $\begin{aligned} & 200 \\ & 300 \end{aligned}$ | 400 | ns typ <br> ns max | Test Circuit 8 |
| OFF Isolation | $\begin{aligned} & 68 \\ & 50 \end{aligned}$ |  | $\begin{aligned} & 68 \\ & 50 \end{aligned}$ |  | $\begin{aligned} & 68 \\ & 50 \end{aligned}$ |  | dB typ <br> dB min | $\begin{aligned} & \mathrm{V}_{\mathrm{EN}}=0.8 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}, \\ & \mathrm{~V}_{\mathrm{S}}=7 \mathrm{Vrms}, \mathrm{f}=100 \mathrm{kHz} \end{aligned}$ |
| $\mathrm{C}_{\text {S }}$ (OFF) | 5 |  | 5 |  | 5 |  | pF typ | $\mathrm{V}_{\mathrm{EN}}=0.8 \mathrm{~V}$ |
| $\mathrm{C}_{\mathrm{D}}$ (OFF) |  |  |  |  |  |  |  |  |
| ADG508A | 22 |  | 22 |  | 22 |  | pF typ | $\mathrm{V}_{\mathrm{EN}}=0.8 \mathrm{~V}$ |
| ADG509A | 11 | $\checkmark$ | 11 |  | 11 |  | pF typ |  |
| Qinj, Charge Injection |  |  | 4 |  | 4 |  | pC typ | $\mathrm{R}_{\mathrm{S}}=0 \Omega, \mathrm{~V}_{S}=0$; Test Circuit 9 |
| $\begin{aligned} & \text { POWER SUPPLY } \\ & \text { I DD } \end{aligned}$ | 0.6 | 1.5 | 0.6 | 1.5 | 0.6 | 1.5 | mA typ $m A$ max | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {INL }}$ or $\mathrm{V}_{\text {INH }}$ |
| Iss | 20 | 0.2 | 20 | 0.2 | 20 | 0.2 | $\mu A$ typ $m A$ max | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {INL }}$ or $\mathrm{V}_{\text {INH }}$ |
| Power Dissipation | 10 | 28 | 10 | 28 | 10 | 28 | mW typ $\operatorname{mW} \max$ |  |

## NOTE

${ }^{1}$ Sample tested at $25^{\circ} \mathrm{C}$ to ensure compliance.
Specifications subject to change without notice.

SINGLE SUPPLY ${ }_{\left(\mathrm{v}_{00}\right.}=+10.8 \mathrm{~V}$ to $+16.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=$ GNO $=$ ov unless otherise noted. $)$

| Parameter |  | ADG508A ADG509A K Version |  | ADG508A ADG509A B Version |  | $\begin{aligned} & \text { ADG508A } \\ & \text { ADG509A } \\ & \text { TVersion } \\ & \hline \end{aligned}$ |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $+25^{\circ} \mathrm{C}$ | $\begin{aligned} & -40^{\circ} \mathrm{Cto} \\ & +85^{\circ} \mathrm{C} \end{aligned}$ | $+25^{\circ} \mathrm{C}$ | $\begin{aligned} & -40^{\circ} \mathrm{C} \text { to } \\ & +85^{\circ} \mathrm{C} \end{aligned}$ | $+25^{\circ} \mathrm{C}$ | $\begin{aligned} & -55^{\circ} \mathrm{C} \text { to } \\ & +125^{\circ} \mathrm{C} \end{aligned}$ | Units | Comments |
| ANALOGSWITCH |  |  |  |  |  |  |  |  |  |
| Analog Signal Range |  | GND | GND | GND | GND | GND | GND | V min |  |
|  |  | $\mathrm{V}_{\mathrm{DD}}$ | $V_{\text {DD }}$ | $\mathrm{V}_{\text {DD }}$ | $V_{\text {DD }}$ | $\mathrm{V}_{\text {DD }}$ | $\mathrm{V}_{\mathrm{DD}}$ | $V_{\text {max }}$ |  |
| Ron |  | 500 |  | 500 |  | 500 |  | $\Omega$ typ | $\mathrm{GND} \leq \mathrm{V}_{\mathrm{S}} \leq+10 \mathrm{~V}, \mathrm{I}_{\mathrm{DS}}=0.5 \mathrm{~mA}$; Test Circuit 1 |
|  |  | 700 | 1000 | 700 | 1000 |  | 1000 | $\Omega$ max |  |
|  |  | 0.6 |  | 0.6 |  | 0.6 |  | \%/ ${ }^{\circ} \mathrm{C}$ typ | $\mathrm{V}_{\mathrm{s}}=0, \mathrm{I}_{\text {DS }}=0.5 \mathrm{~mA}$ |
| $\mathrm{R}_{\mathrm{ON}}$ Match |  | 5 |  | 5 |  | 5 |  | \%typ | GND $\leq \mathrm{V}_{\mathrm{S}} \leq+10 \mathrm{~V}, \mathrm{I}_{\text {DS }}=0.5 \mathrm{~mA}$ |
| $\mathrm{I}_{\mathbf{S}}$ (OFF), Off Input Leakage |  | 0.02 |  | 0.02 |  | 0.02 |  | nA typ | $\mathrm{V} 1=+10 \mathrm{~V} / \mathrm{GND}, \mathrm{V} 2=\mathrm{GND} /+10 \mathrm{~V}$, |
|  |  |  | 50 |  | 50 |  | 50 | $n A$ max | Test Circuit 2 |
| $\mathrm{I}_{\mathrm{D}}$ (OFF), Off Output Leakage ADG508A |  | 0.04 |  | 0.04 |  | 0.04 |  | nA typ | $\mathrm{V} 1=+10 \mathrm{~V} / \mathrm{GND}, \mathrm{V} 2=\mathrm{GND} /+10 \mathrm{~V}$; |
|  |  | 1 | 100 | 1 | 100 |  | 100 | $n \mathrm{~A}_{\text {max }}$ | Test Circuit 3 |
| ADG509A |  | 1 | 50 |  | 50 | 1 | 50 | $n A$ max |  |
| $I_{D}(O N)$, On Channel Leakage ADG508A |  | 0.04 |  | 0.04 |  | 0.04 |  | nA typ | $\mathrm{V} 1=\mathrm{V} 2=+10 \mathrm{~V} / \mathrm{GND}$; |
|  |  | 1 | 100 |  | 100 |  | 100 | nA max | Test Circuit 4 |
| ADG509A |  | 1 | 50 |  | 50 | 1 | 50 | $n A$ max |  |
| I $_{\text {DIFF }}$, Differential Off Output Leakage (ADG509A only) |  |  | 25 |  | 25 |  | 25 | $n A_{\text {max }}$ | $\begin{aligned} & \mathrm{V1}=+10 \mathrm{~V} / \mathrm{GND}, \mathrm{~V} 2=\mathrm{GND} /+10 \mathrm{~V} ; \\ & \text { Test Circuit } 5 \end{aligned}$ |
| DIGITALCONTROL <br> $\mathbf{V}_{\text {INH }}$, Input High Voltage <br> $V_{\text {INL }}$, Input Low Voltage $\mathrm{I}_{\mathbf{N L L}}$ or $\mathrm{I}_{\mathrm{INH}}$ $\mathrm{C}_{\text {IN }}$ Digital Input Capacitance |  |  |  |  |  |  |  |  |  |
|  |  |  | 2.4 |  | 2.4 |  | 2.4 | $V_{\text {min }}$ |  |
|  |  |  | 0.8 |  | 0.8 |  | 0.8 | $V_{\text {max }}$ |  |
|  |  | 8 | 1 | 8 | 1 | 8 | 1 | $\mu \mathrm{A}$ max pF max | $\mathrm{V}_{\text {IN }}=0 \mathrm{to}^{\text {V }} \mathrm{DD}$ |
| $\underset{\mathrm{t}_{\text {TRANSITIION }}{ }^{1}}{ }{ }^{\text {DYNARACTERISTICS }}$ |  |  |  |  |  |  |  |  |  |
|  |  | 300 |  | 300 |  | 300 |  | nstyp | $\mathrm{V} 1=+10 \mathrm{~V} / \mathrm{GND}, \mathrm{V} 2=\mathrm{GND} /+10 \mathrm{~V}$; Test Circuit 6 |
|  |  | 450 | 600 |  | 600 |  | 600 | ns max |  |
| topen ${ }^{1}$ |  | 50 |  | 50 |  | 50 |  | nstyp | Test Circuit 7 |
|  |  |  | 10 |  | 10 |  | 10 | ns min |  |
| $\left.\mathrm{ton}^{(\mathrm{EN}}\right)^{1}$ |  | 250 |  | 250 |  | 250 |  | nstyp | Test Circuit 8 |
|  |  | 450 | 600 | 450 | 600 | 450 | 600 | ns max |  |
| $\mathrm{toff}^{(E N)}{ }^{1}$ |  | 250 |  | 250 |  | 250 |  | nstyp | Test Circuit 8 |
|  |  |  | 600 | 450 | 600 | 450 | 600 | ns max |  |
| OFF Isolation |  | 68 |  | 68 |  | 68 |  | dB typ | $\mathrm{V}_{\mathrm{EN}}=0.8 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$, |
|  |  | 50 |  | 50 |  | 50 |  | dB min | $\mathrm{V}_{\mathrm{s}}=3.5 \mathrm{~V} \mathrm{rms}, \mathrm{f}=100 \mathrm{kHz}$ |
| $\mathrm{C}_{\text {S }}$ (OFF) |  | 5 |  | 5 |  | 5 |  | pF typ | $\mathrm{V}_{\mathrm{EN}}=0.8 \mathrm{~V}$ |
| $\mathrm{C}_{\mathrm{D}}$ (OFF) |  |  |  |  |  |  |  |  |  |
| ADG508AADG509A |  | 22 |  | 22 |  | 22 |  | pF typ | $\mathrm{V}_{\mathrm{EN}}=0.8 \mathrm{~V}$ |
|  |  | 11 |  | 11 |  | 11 |  | pF typ |  |
| Qinj, Charge Injection |  | 4 |  | 4 |  | 4 |  | pCtyp | $\mathrm{R}_{\mathrm{S}}=0 \Omega, \mathrm{~V}_{\mathrm{S}}=0 \mathrm{~V}$; Test Circuit 9 |
| POWER SUPPLY |  |  |  |  |  |  |  |  |  |
| $\mathrm{I}_{\mathrm{DD}}$ |  | 0.6 |  | 0.6 |  | 0.6 |  | mA typ | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {INL }}$ or $\mathrm{V}_{\text {INH }}$ |
|  |  |  | 1.5 |  | 1.5 |  | 1.5 | mA max |  |
| Power Dissipation |  | 10 |  | 10 |  | 10 |  | mW typ |  |
|  |  |  | 25 |  | 25 |  | 25 | mW max |  |
| NOTE <br> ${ }^{1}$ Sample tested at $25^{\circ} \mathrm{C}$ to ensure compliance. |  |  |  |  |  |  | $\mathrm{C}_{\text {IN }}$ |  | input capacitance |
|  |  |  |  |  |  |  |  |  | al input capacitance |
| Specifications subject to change without notice. |  |  |  |  |  |  | toff (EN) |  | y time between the $50 \%$ and $10 \%$ points of |
| TERMINOLOGY |  |  |  |  |  |  |  |  | igital input and switch "OFF" condition |
| $\mathrm{R}_{\mathrm{ON}} \quad$ Ohmic resis |  | ance be | tween ter | minals D | and S |  | Transt |  | igital inputs and switch "ON" condition |
| $\mathrm{R}_{\text {ON }}$ Match Difference b |  | etween | the $\mathrm{R}_{\mathrm{ON}}$ | f any $t$ | wo chann |  |  |  | switching from one address state to |
| $\mathrm{R}_{\text {ON }}$ Drift Change in R |  | On vers | us temper | ature |  |  |  |  |  |
| $\mathrm{I}_{\mathbf{S}}$ (OFF) | Source terminal leakage current when the switc is off |  |  |  |  |  | topen |  | F" time measured between $50 \%$ points of switches when switching from one address |
| $\mathrm{I}_{\mathrm{D}}$ (OFF) | Drain terminal leakage current when the switch is off |  |  |  |  |  |  |  | to another |
|  |  |  |  |  |  |  | $V_{\text {InL }}$ |  | mum input voltage for Logic "0" |
| $\mathrm{I}_{\mathrm{D}}(\mathrm{ON})$ | Leakage current that flows from the closed switchinto the body |  |  |  |  |  | $\mathrm{V}_{\mathrm{INH}}$ <br> $\mathrm{I}_{\text {INL }}\left(\mathrm{I}_{\text {INH }}\right)$ | Min | mum input voltage for Logic " 1 " current of the digital input |
| $\mathrm{V}_{\mathrm{S}}\left(\mathrm{V}_{\mathrm{D}}\right) \quad$ Analog volt |  | ge on te | rminal S | or D |  |  | $V_{\text {DD }}$ | Mos | positive voltage supply |
| $\mathrm{C}_{S}$ (OFF) Channel in |  | t capac | citance for | "OFF" | conditio |  | $V_{\text {Ss }}$ | Mos | negative voltage supply |
| $\mathrm{C}_{\mathrm{D}}$ (OFF) | Channel out condition | ut capa | acitance for | "OFF |  |  | IDD | Posi | ive supply current |
|  |  |  |  |  |  |  | Iss | Neg | ative supply current |

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$



## TRUTH TABLES

| A2 | A1 | A0 | EN | ON SWITCH |
| :--- | :---: | :---: | :---: | :---: |
| X | X | X | 0 | NONE |
| 0 | 0 | 0 | 1 | 1 |
| 0 | 0 | 1 | 1 | 2 |
| 0 | 1 | 0 | 1 | 3 |
| 0 | 1 | 1 | 1 | 4 |
| 1 | 0 | 0 | 1 | 5 |
| 1 | 0 | 1 | 1 | 6 |
| 1 | 1 | 0 | 1 | 7 |
| 1 | 1 | 1 | 1 | 8 |

$\mathrm{X}=$ Don't Care $\quad$ ADG508A

## CAUTION

CAUTION
ESD (Electro-Static-Discharge) sensitive device. The digital control inputs are diode protected;
however, permanent damage may occur on unconnected devices subject to high energy electrostatic
fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be
discharged to the destination socket before devices are removed.
CAUTION
ESD (Electro-Static-Discharge) sensitive device. The digital control inputs are diode protected;
however, permanent damage may occur on unconnected devices subject to high energy electrostatic
fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be
discharged to the destination socket before devices are removed.
CAUTION
ESD (Electro-Static-Discharge) sensitive device. The digital control inputs are diode protected;
however, permanent damage may occur on unconnected devices subject to high energy electrostatic
fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be
discharged to the destination socket before devices are removed. discharged to the destination socket before devices are removed.

Derates above $+75^{\circ} \mathrm{C}$ by . . . . . . . . . . . . . . $6 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$

Operating Temperature
Commercial (K Version) . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Industrial (B Version) . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Extended (T Version) . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10sec) . . . . . . . . . $+300^{\circ} \mathrm{C}$

NOTES
${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ Overvoltage at A, EN, S or D will be clamped by diodes. Current should be limited to the Maximum Rating above.


PIN CONFIGURATIONS

| A1 | A0 | EN | ON <br> PAIR |
| :--- | :--- | :---: | :---: |
| X | X | 0 | NONE |
| 0 | 0 | 1 | 1 |
| 0 | 1 | 1 | 2 |
| 1 | 0 | 1 | 3 |
| 1 | 1 | 1 | 4 |

X = Don't Care

## ADG508F/ADG509F/ADG528F/ADG529F

## FEATURES

Wide Supply Ranges ( 10.8 V to 16.5 V )
Low On Resistance ( $300 \Omega$ max)
Fast Switching Times
$t_{0 N} 300$ ns max
$t_{\text {OFF }} 300$ ns max
Low Power Dissipation ( 3.3 mW max)
Fault and Overvoltage Protection
All Switches OFF with Power Supply OFF
ON Channel Turns OFF if Overvoltage Occurs
Latch-Up Proof Construction
Break-Before-Make Construction
TTL and CMOS Compatible Inputs
Superior Alternative to MAX358/MAX359
DG458/DG459
FUNCTIONAL BLOCK DIAGRAMS

APPLICATIONS

## Data Acquisition Systems

Industrial and Process Control Systems
Avionics Test Equipment
Signal Routing Between Systems
High Reliability Control Systems

## GENERAL DESCRIPTION

The ADG508F, ADG509F, ADG528F and ADG529F are CMOS analog multiplexers comprising eight single channels and four differential channels respectively which have fault protection. Using a series n -channel, p-channel, n -channel MOSFET structure, both device and signal source protection is provided in the event of an overvoltage or power loss. The multiplexer can withstand continuous overvoltage inputs up to $\pm 35 \mathrm{~V}$. During fault conditions, the multiplexer input (or output) appears as an open circuit and only a few nanoamperes of leakage current will flow. This protects not only the multiplexer and the circuitry driven by the multiplexer, but also protects the sensors or signal sources that drive the multiplexer.
The ADG508F/ADG509F/ADG528F/ADG529F are designed on an enhanced LC ${ }^{2}$ MOS, trench-isolated process that provides low power dissipation yet gives high switching speed and low on resistance. All channels exhibit break-before-make switching action preventing momentary shorting when switching channels.
The ADG508F and ADG528F switch one of eight inputs to a common output as determined by the 3-bit binary address lines A0, A1 and A2. The ADG509F and ADG529F switch one of four differential inputs to a common differential output as determined by the 2-bit binary address lines A0 and A1. The ADG528F and ADG529F have on-chip address and control latches that facilitate microprocessor interfacing. An EN input on each device is used to enable or disable the device. When disabled, all channels are switched OFF.

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## PRODUCT HIGHLIGHTS

1. Fault Protection

The ADG508F/ADG509F/ADG528F/ADG529F can withstand continuous voltage inputs up to $\pm 35 \mathrm{~V}$. When a fault occurs, due to the power supplies being turned off or due to an overvoltage being applied to the ADG508F/ADG509F/ ADG528F/ADG529F, all the channels are turned off and only a leakage current of a few nanoamperes flows.
2. Dual Supply Specifications with a Wide Tolerance The devices are specified in the 10.8 V to 16.5 V range.
3. Low $\mathrm{R}_{\mathrm{ON}}$
4. Fast Switching Times
5. Break-Before-Make Switching

Switches are guaranteed break-before-make so that input signals are protected against momentary shorting.
6. Trench Isolation Guards Against Latch Up A dielectric trench separates the p and $n$-channel MOSFETs thereby preventing latch-up.

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

Dual Supply ( $\mathrm{V}_{00}=+10.8 \mathrm{~V}$ to $+16.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=-10.8 \mathrm{~V}$ to -16.5 V , GND $=0 \mathrm{~V}$, unless otherwise noted)


## NOTES

${ }^{1}$ Temperature ranges are as follows: B Versions: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; T Versions: $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
${ }^{2}$ Guaranteed by design, not subject to production test.
Specifications subject to change without notice.
This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

## ADG508F/ADG509F/ADG528F/ADG529F

| BSOLUTE MAXIMUM RATINGS* |  |
| :---: | :---: |
| $+25^{\circ} \mathrm{C}$ unless otherwise noted) |  |
| $\mathrm{V}_{\mathrm{DD}}$ to $\mathrm{V}_{\text {S }}$ |  |
| $\mathrm{V}_{\mathrm{DD}}$ to GND |  |
| $\mathrm{V}_{\text {Ss }}$ to GND |  |
| $\mathrm{V}_{\mathrm{EN}}, \mathrm{V}_{\mathrm{A}}$ Digital Input |  |
| $\mathrm{V}_{\mathrm{S}}$, Analog Input Overvoltage with Power ON. .... V $\mathrm{V}_{\text {SS }}-20 \mathrm{~V}$ <br> to $\mathrm{V}_{\mathrm{DD}}+20 \mathrm{~V}$ |  |
| $\mathrm{V}_{S}$, Analog Input Overvoltage with Power OFF |  |
|  | to +35 V |
| Continuous Current, S or D |  |
| Peak Current, S or D |  |
| Operating Temperature Range |  |
| Industrial (B Version) |  |
| Extended (T Version) |  |
| Storage Temperature Range |  |
| Junction Temperature |  |
| Cerdip Package, Power Dissipation |  |
| $\theta_{\mathrm{JA}}$, Thermal Impedance |  |
| Lead Temperature, Soldering (10 sec) |  |
| Plastic Package, Power Dissipation . . . . . . . . . . . . . . 470 mW |  |
| $\theta_{\mathrm{JA}}$, Thermal Impedance . . . . . . . . . . . . . . . . . . . . $117^{\circ} \mathrm{C} / \mathrm{W}$ |  |
| Lead Temperature, Soldering (10 sec) . . . . . . . . . . $+260^{\circ} \mathrm{C}$ |  |
| OIC Package, Power Dissipation . . . . . . . . . . . . . . . 600 mW |  |
| $\theta_{\mathrm{JA}}$, Thermal Impedance. . . . . . . . . . . . . . . . . . . . $77^{\circ} \mathrm{C} / \mathrm{W}$ |  |
| Lead Temperature, Soldering |  |
| Vapor Phase (60 sec) |  |
| Infrared (15 sec) |  |
| PLCC Package, Power Dissipation |  |
| $\theta_{\mathrm{JA}}$, Thermal Impedance |  |
| Lead Temperature, Soldering |  |
| Vapor Phase (60 sec) |  |
| Infrared (15 sec) | $+220^{\circ} \mathrm{C}$ |

*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Only one absolute maximum rating may be applied at any one time.


NC = NO CONNECT

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although these devices feature proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

ORDERING GUIDE

| Model $^{1}$ | Temperature Range | Package Option ${ }^{2}$ |
| :--- | :--- | :--- |
| ADG508FBN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| ADG508FBR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16 \mathrm{~A}$ |
| ADG508FBP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{P}-20 \mathrm{~A}$ |
| ADG508FTQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| ADG509FBN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| ADG509FBR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16 \mathrm{~A}$ |
| ADG509FBP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{P}-20 \mathrm{~A}$ |
| ADG509FTQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| ADG528FBN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-18$ |
| ADG528FBP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{P}-20 \mathrm{~A}$ |
| ADG528FTQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-18$ |
| ADG529FBN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-18$ |
| ADG529FBP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{P}-20 \mathrm{~A}$ |
| ADG529FTQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-18$ |

## NOTES

${ }^{1}$ To order MIL-STD-883, Class B processed parts, add /883B to T grade part numbers.
${ }^{2} \mathrm{~N}=$ Plastic DIP; $\mathrm{P}=$ Plastic Leaded Chip Carrier (PLCC); $\mathrm{Q}=$ Cerdip; $R=0.15^{\prime \prime}$ Small Outline IC (SOIC). For outline information see Package Information section.

Table I. ADG508F Truth Table

| A2 | A1 | A0 | EN | ON SWITCH |
| :--- | :--- | :--- | :--- | :--- |
| $\mathbf{X}$ | $\mathbf{X}$ | $\mathbf{X}$ | 0 | NONE |
| 0 | 0 | 0 | 1 | 1 |
| 0 | 0 | 1 | 1 | 2 |
| 0 | 1 | 0 | 1 | 3 |
| 0 | 1 | 1 | 1 | 4 |
| 1 | 0 | 0 | 1 | 5 |
| 1 | 0 | 1 | 1 | 6 |
| 1 | 1 | 0 | 1 | 7 |
| 1 | 1 | 1 | 1 | 8 |
|  |  |  |  |  |
| X Don't Care |  |  |  |  |

Table II. ADG509F Truth Table

| $\mathbf{A 1}$ | A0 | EN | ON SWITCH PAIR |
| :--- | :--- | :--- | :--- |
| $\mathbf{X}$ | $\mathbf{X}$ | 0 | NONE |
| 0 | 0 | 1 | 1 |
| 0 | 1 | 1 | 2 |
| 1 | 0 | 1 | 3 |
| 1 | 1 | 1 | 4 |

X = Don't Care:

Table III. ADGS28F Truth Table

$\mathrm{X}=$ Don't Care
Table IV. ADG529F Truth Table

| $\mathbf{A 1}$ | $\mathbf{A 0}$ | $\mathbf{E N}$ | $\overline{\mathbf{W R}}$ | $\overline{\mathbf{R S}}$ | ON <br> SWITCH PAIR |
| :--- | :--- | :--- | :--- | :--- | :--- |
| $\mathbf{X}$ | $\mathbf{X}$ | $\mathbf{X}$ | $\mathbf{5}$ | 1 | Retains Previous Switch Condition |
| $\mathbf{X}$ | $\mathbf{X}$ | $\mathbf{X}$ | $\mathbf{X}$ | 0 | NONE (Address and Enable |
|  |  |  |  |  | Latches Cleared) |
| $\mathbf{X}$ | $\mathbf{X}$ | 0 | 0 | 1 | NONE |
| 0 | 0 | 1 | 0 | 1 | 1 |
| 0 | 1 | 1 | 0 | 1 | 2 |
| 1 | 0 | 1 | 0 | 1 | 3 |
| 1 | 1 | 1 | 0 | 1 | 4 |

[^103]This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

## FEATURES

+3 V, +5 V or $\pm 5$ V Power Supplies
Ultralow Power Dissipation ( $<0.5 \mu \mathrm{~W}$ )
Low Leakage (<100 pA)
Low On Resistance (<50 $\Omega$ )
Fast Switching Times
Low Charge Injection
Latch-Up Proof
TTL/CMOS Compatible
16-Pin DIP or SOIC Package

## APPLICATIONS

Battery Powered Instruments
Single Supply Systems
Remote Powered Equipment
+5 V Supply Systems
Computer Peripherals such as Disk Drives
Precision Instrumentation
Audio and Video Switching
Automatic Test Equipment
Precision Data Acquisition
Sample Hold Systems
Communication Systems
Compatible with $\pm 5$ V Supply DACs and ADCs such as AD7840/8, AD7870/1/2/4/5/6/8

## GENERAL DESCRIPTION

The ADG511, ADG512 and ADG513 are monolithic CMOS ICs containing four independently selectable analog switches. These switches feature low, well-controlled on resistance and wide analog signal range, making them ideal for precision analog signal switching.
These switch arrays are fabricated using Analog Devices' advanced linear compatible CMOS ( $\mathrm{LC}^{2}$ MOS) process which offers the additional benefits of low leakage currents, ultralow power dissipation and low capacitance for fast switching speeds with minimum charge injection. These features make the ADG511, ADG512 and ADG513 the optimum choice for a wide variety of signal switching tasks in precision analog signal processing and data acquisition systems.
The ability to operate from single $+3 \mathrm{~V},+5 \cdot \mathrm{~V}$ or $\pm 5 \mathrm{~V}$ bipolar supplies make the ADG511, ADG512 and ADG513 perfect for use in battery-operated instruments, 4-20 mA loop systems and with the new generation of DACs and ADCs from Analog Devices. The use of 5 V supplies and reduced operating currents give much lower power dissipation than devices operating from $\pm 15 \mathrm{~V}$ supplies.

## FUNCTIONAL BLOCK DIAGRAM





SWITCHES SHOWN FOR A LOGIC " 1 " INPUT

The ADG511, ADG512 and ADG513 contain four independent SPST switches. The ADG511 and ADG512 differ only in that the digital control logic is inverted. The ADG511 switch is turned on with a logic low on the appropriate control input, while a logic high is required for the ADG512. The ADG513 contains two switches whose digital control logic is similar to that of the ADG511 while the logic is inverted in the remaining two switches.

## PRODUCT HIGHLIGHTS

1. +5 Volt Single Supply Operation

The ADG511/ADG512/ADG513 offers high performance, including low on resistance and wide signal range, fully specified and guaranteed with $+3 \mathrm{~V}, \pm 5 \mathrm{~V}$ as well as +5 V supply rails.
2. Ultralow Power Dissipation CMOS construction ensures ultralow power dissipation.
3. Low $\mathrm{R}_{\mathrm{ON}}$
4. Trench Isolation Guards Against Latch-up A dielectric trench separates the P and N channel transistors thereby preventing latch-up even under severe overvoltage conditions.
5. Break Before Make Switching

Switches are guaranteed to have break-before-make operation. This allows multiple outputs to be tied together for multiplexer applications without the possibility of momentary shorting between channels.

[^104]
## SPECIFICATIONS ${ }^{1}$

Dual Supply $\mathrm{V}_{00}=+5 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{\mathrm{SS}}=-5 \mathrm{~V} \pm 10 \%$, $\mathrm{GND}=0 \mathrm{~V}$, unless othemise noted)

| Parameter | $$ |  | $$ |  | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ANALOG SWITCH Analog Signal Range $\mathrm{R}_{\mathrm{ON}}$ | $30$ | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}} \text { to } \mathrm{V}_{\mathrm{Ss}} \\ & 50 \end{aligned}$ | 30 | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}} \text { to } \mathrm{V}_{\mathrm{Ss}} \\ & 50 \end{aligned}$ | $\begin{aligned} & \mathrm{v} \\ & \Omega \text { typ } \\ & \Omega_{\text {max }} \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{D}}= \pm 3.5 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=-10 \mathrm{~mA} ; \\ & \mathrm{V}_{\mathrm{DD}}=+4.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{ss}}=-4.5 \mathrm{~V} \end{aligned}$ |
| LEAKAGE CURRENTS <br> Source OFF Leakage $\mathrm{I}_{\mathrm{S}}$ (OFF) <br> Drain OFF Leakage $I_{D}$ (OFF) <br> Channel ON Leakage $\mathrm{I}_{\mathrm{D}}, \mathrm{I}_{\mathrm{S}}(\mathrm{ON})$ | $\begin{aligned} & \pm 0.025 \\ & \pm 0.1 \\ & \pm 0.025 \\ & \pm 0.1 \\ & \pm 0.05 \\ & \pm 0.2 \end{aligned}$ | $\begin{aligned} & \pm 2.5 \\ & \pm 2.5 \\ & \pm 5 \end{aligned}$ | $\begin{aligned} & \pm 0.025 \\ & \pm 0.1 \\ & \pm 0.025 \\ & \pm 0.1 \\ & \pm 0.05 \\ & \pm 0.2 \end{aligned}$ | $\begin{aligned} & \pm 2.5 \\ & \pm 2.5 \\ & \pm 5 \end{aligned}$ | nA typ nA max nA typ nA max nA typ nA max | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=+5.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{ss}}=-5.5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{D}}= \pm 4.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{s}}=\mp 4.5 \mathrm{~V} ; \\ & \text { Test Circuit } 2 \\ & \mathrm{~V}_{\mathrm{D}}= \pm 4.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{s}}=\mp 4.5 \mathrm{~V} ; \\ & \text { Test Circuit } 2 \\ & \mathrm{~V}_{\mathrm{D}}=\mathrm{V}_{\mathrm{s}}= \pm 4.5 \mathrm{~V} ; \\ & \text { Test Circuit } 3 \end{aligned}$ |
| DIGITAL INPUTS <br> Input High Voltage, $\mathrm{V}_{\text {INH }}$ Input Low Voltage, $\mathrm{V}_{\text {INL }}$ Input Current $\mathrm{I}_{\text {INL }}$ or $\mathrm{I}_{\text {INH }}$ | 0.005 | $\begin{aligned} & 2.4 \\ & 0.8 \end{aligned}$ $\pm 0.1$ | 0.005 | $\begin{aligned} & 2.4 \\ & 0.8 \\ & \\ & \pm 0.1 \end{aligned}$ | V min V max <br> $\mu \mathrm{A}$ typ $\mu \mathrm{A}$ max | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {INL }}$ or $\mathrm{V}_{\text {INH }}$ |
| DYNAMIC CHARACTERISTICS ${ }^{2}$ <br> $\mathrm{t}_{\mathrm{ON}}$ <br> $t_{\text {off }}$ <br> Break-Before-Make Time Delay, $t_{\mathrm{D}}$ (ADG513 Only) Charge Injection <br> OFF Isolation <br> Channel-to-Channel Crosstalk <br> $\mathrm{C}_{\mathrm{s}}$ (OFF) <br> $\mathrm{C}_{\mathrm{D}}$ (OFF) <br> $\mathrm{C}_{\mathrm{D}}, \mathrm{C}_{\mathrm{s}}(\mathrm{ON})$ | $\begin{aligned} & 200 \\ & 120 \\ & 100 \\ & 11 \\ & 68 \\ & 85 \\ & 9 \\ & 9 \\ & 35 \end{aligned}$ | 375 150 | $\begin{aligned} & 200 \\ & 120 \\ & 100 \\ & 11 \\ & 68 \\ & 85 \\ & 9 \\ & 9 \\ & 35 \end{aligned}$ | 375 150 | ns typ ns max ns typ ns max ns typ pC typ dB typ dB typ pF typ pF typ pF typ |  |
| POWER REQUIREMENTS <br> $V_{D D}$ <br> $\mathrm{V}_{\text {ss }}$ <br> $I_{D D}$ <br> $\mathrm{I}_{\mathrm{ss}}$ | $\begin{aligned} & 0.0001 \\ & 0.0001 \end{aligned}$ | $\begin{aligned} & +4.5 / 5.5 \\ & -4.5 /-5.5 \end{aligned}$ <br> 1 $1$ | $\begin{aligned} & 0.0001 \\ & 0.0001 \end{aligned}$ | $\begin{aligned} & +4.5 / 5.5 \\ & -4.5 /-5.5 \\ & 1 \\ & 1 \end{aligned}$ | $\mathrm{V} \min / \max$ <br> V min/max $\mu \mathrm{A}$ typ $\mu A \max$ $\mu \mathrm{A}$ typ $\mu \mathrm{A}$ max | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=+5.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{ss}}=-5.5 \mathrm{~V} \\ & \text { Digital Inputs }=0 \mathrm{~V} \text { or } 5 \mathrm{~V} \end{aligned}$ |

## NOTES

${ }^{1}$ Temperature ranges are as follows: B Versions $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; T Versions $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
${ }^{2}$ Guaranteed by design, not subject to production test.
Specifications subject to change without notice.

## ADG511/ADG512/ADG513-SPECIFICATIONS ${ }^{1}$

Single Supply ${ }_{\left(V_{D O}\right.}=+5 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{GND}=0 \mathrm{~V}$, unless otherwise noted)

| Parameter | $$ | $\begin{array}{\|c} \text { T Version } \\ -55^{\circ} \mathrm{C} \text { to } \\ +25^{\circ} \mathrm{C} \quad+125^{\circ} \mathrm{C} \end{array}$ | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: |
| ANALOG SWITCH Analog Signal Range $\mathrm{R}_{\mathrm{ON}}$ | $\begin{array}{ll}  & 0 . V \text { to } V_{D D} \\ 45 & 75 \end{array}$ | $\begin{array}{ll}  & 0 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{DD}} \\ 45 & 75 \end{array}$ | V <br> $\Omega$ typ <br> $\Omega$ max | $\begin{aligned} & \mathrm{V}_{\mathrm{D}}=3.5 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=-10 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{DD}}=+4.5 \mathrm{~V} \end{aligned}$ |
| LEAKAGE CURRENTS <br> Source OFF Leakage $I_{S}$ (OFF) <br> Drain OFF Leakage $I_{D}$ (OFF) <br> Channel ON Leakage $I_{D}, I_{S}(O N)$ | $\begin{array}{ll}  \pm 0.025 & \\ \pm 0.1 & \pm 2.5 \\ \pm 0.025 & \\ \pm 0.1 & \pm 2.5 \\ \pm 0.05 & \\ \pm 0.2 & \pm 5 \end{array}$ | $\begin{array}{ll}  \pm 0.025 & \\ \pm 0.1 & \pm 2.5 \\ \pm 0.025 & \\ \pm 0.1 & \pm 2.5 \\ \pm 0.05 & \\ \pm 0.2 & \pm 5 \end{array}$ | nA typ nA max nA typ $n A$ max nA typ nA max | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=+5.5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{D}}=4.5 / 1 \mathrm{~V}, \mathrm{~V}_{\mathrm{s}}=1 / 4.5 \mathrm{~V} \end{aligned}$ <br> Test Circuit 2 $\mathrm{V}_{\mathrm{D}}=4.5 / 1 \mathrm{~V}, \mathrm{~V}_{\mathrm{S}}=1 / 4.5 \mathrm{~V}$ <br> Test Circuit 2 $\mathrm{V}_{\mathrm{D}}=\mathrm{V}_{\mathrm{s}}=+4.5 \mathrm{~V} /+1 \mathrm{~V}$ <br> Test Circuit 3 |
| DIGITAL INPUTS <br> Input High Voltage, $\mathrm{V}_{\text {INH }}$ Input Low Voltage, $\mathrm{V}_{\text {INL }}$ Input Current $\mathrm{I}_{\text {INL }}$ or $\mathrm{I}_{\text {INH }}$ | $\begin{array}{ll}  & 2.4 \\ & 0.8 \\ & \\ 0.005 & \\ & \pm 0.1 \end{array}$ | $\begin{array}{\|cc}  & 2.4 \\ & 0.8 \\ & \\ 0.005 & \\ & \pm 0.1 \end{array}$ | V min <br> V max <br> $\mu \mathrm{A}$ typ <br> $\mu \mathrm{A}$ max | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{INL}}$ or $\mathrm{V}_{\mathrm{IN}}$ |
| DYNAMIC CHARACTERISTICS ${ }^{2}$ <br> $\mathrm{t}_{\mathrm{ON}}$ <br> $t_{\text {OFF }}$ <br> Break-Before-Make Time <br> Delay, $t_{D}$ (ADG513 only) <br> Charge Injection <br> OFF Isolation <br> Channel-to-Channel Crosstalk <br> $\mathrm{C}_{\mathrm{S}}$ (OFF) <br> $\mathrm{C}_{\mathrm{D}}$ (OFF) <br> $\mathrm{C}_{\mathrm{D}}, \mathrm{C}_{\mathrm{S}}(\mathrm{ON})$ | 250 500 <br> 50  <br> 200  <br> 16  <br> 68  <br> 85  <br> 9  <br> 9  <br> 35  | 250  <br> 50 500 <br> 200 100 <br> 16  <br> 68  <br> 85  <br> 9  <br> 9  <br> 35  | ns typ ns max ns typ ns max ns typ pC typ dB typ dB typ pF typ pF typ pF typ | $\mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF} ;$ <br> $\mathbf{V}_{\mathbf{S}}=+2 \mathrm{~V}$; Test Circuit 4 <br> $\mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}$; <br> $\mathbf{V}_{\mathrm{S}}=+2 \mathrm{~V}$; Test Circuit 4 <br> $\mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}$; <br> $\mathrm{V}_{\mathbf{S} 1}=\mathrm{V}_{\mathrm{S} 2}=+2 \mathrm{~V}$; Test Circuit 5 <br> $\mathrm{V}_{\mathrm{S}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{S}}=0 \Omega, \mathrm{C}_{\mathrm{L}}=10 \mathrm{nF}$; <br> Test Circuit 6 <br> $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{f}=1 \mathrm{MHz} ;$ <br> Test Circuit 7 $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{f}=1 \mathrm{MHz}$ <br> Test Circuit 8 <br> $\mathrm{f}=1 \mathrm{MHz}$ <br> $\mathrm{f}=1 \mathrm{MHz}$ <br> $\mathrm{f}=1 \mathrm{MHz}$ |
| POWER REQUIREMENTS $\begin{aligned} & \mathrm{V}_{\mathrm{DD}} \\ & \mathrm{I}_{\mathrm{DD}} \end{aligned}$ | $\begin{array}{cc}  & 4.5 / 5.5 \\ 0.0001 & 1 \end{array}$ | $\begin{array}{\|ll}  & 4.5 / 5.5 \\ 0.0001 & 1 \end{array}$ | V min/max $\mu \mathrm{A}$ typ $\mu \mathrm{A}$ max | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=+5.5 \mathrm{~V} \\ & \text { Digital Inputs }=0 \mathrm{~V} \text { or } 5 \mathrm{~V} \end{aligned}$ |

NOTES
${ }^{1}$ Temperature ranges are as follows: B Versions $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; T Versions $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
${ }^{2}$ Guaranteed by design, not subject to production test.
Specifications subject to change without notice.


| Parameter | $+25^{\circ} \mathrm{C}$ | sion $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: |
| ANALOG SWITCH Analog Signal Range $\mathrm{R}_{\mathrm{ON}}$ | 200 | $\begin{aligned} & 0 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{DD}} \\ & 500 \end{aligned}$ | V <br> $\Omega$ typ <br> $\Omega$ max | $\begin{aligned} & \mathrm{V}_{\mathrm{D}}=1.5 \mathrm{~V}, \mathrm{I}_{\mathrm{s}}=-1 \mathrm{~mA} ; \\ & \mathrm{V}_{\mathrm{DD}}=+3 \mathrm{~V} \end{aligned}$ |
| LEAKAGE CURRENTS <br> Source OFF Leakage $I_{S}$ (OFF) <br> Drain OFF Leakage $I_{D}$ (OFF) <br> Channel ON Leakage $I_{D}, I_{S}(O N)$ | $\begin{aligned} & \pm 0.025 \\ & \pm 0.1 \\ & \pm 0.025 \\ & \pm 0.1 \\ & \pm 0.05 \\ & \pm 0.2 \end{aligned}$ | $\begin{aligned} & \pm 2.5 \\ & \pm 2.5 \\ & \pm 5 \end{aligned}$ | nA typ nA max nA typ nA max nA typ nA max | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=+3.6 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{D}}=2.6 / 1 \mathrm{~V}, \mathrm{~V}_{\mathrm{s}}=1 / 2.6 \mathrm{~V} \end{aligned}$ <br> Test Circuit 2 $\mathrm{V}_{\mathrm{D}}=2.6 / 1 \mathrm{~V}, \mathrm{~V}_{\mathrm{s}}=1 / 2.6 \mathrm{~V} ;$ <br> Test Circuit 2 $\mathrm{V}_{\mathrm{D}}=\mathrm{V}_{\mathrm{s}}=+2.6 \mathrm{~V} /+1 \mathrm{~V} ;$ <br> Test Circuit 3 |
| DIGITAL INPUTS <br> Input High Voltage, $\mathrm{V}_{\text {INH }}$ Input Low Voltage, $\mathrm{V}_{\text {INL }}$ Input Current $\mathrm{I}_{\text {INL }}$ or $\mathrm{I}_{\text {INH }}$ | 0.005 | $\begin{aligned} & 2.4 \\ & 0.8 \\ & \\ & \pm 0.1 \end{aligned}$ | V min <br> V max <br> $\mu \mathrm{A}$ typ <br> $\mu \mathrm{A} \max$ | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\text {INL }}$ or $\mathrm{V}_{\text {INH }}$ |
| DYNAMIC CHARACTERISTICS ${ }^{2}$ <br> $\mathrm{t}_{\mathrm{ON}}$ <br> $t_{\text {OFF }}$ <br> Break-Before-Make Time <br> Delay, $\mathrm{t}_{\mathrm{D}}$ (ADG513 only) <br> Charge Injection <br> OFF Isolation <br> Channel-to-Channel Crosstalk <br> $\mathrm{C}_{\mathrm{S}}$ (OFF) <br> $\mathrm{C}_{\mathrm{D}}$ (OFF) <br> $\mathrm{C}_{\mathrm{D}}, \mathrm{C}_{\mathrm{S}}(\mathrm{ON})$ | 600 100 500 11 68 85 9 9 35 | 1200 160 | ns typ ns max ns typ ns max ns typ pC typ dB typ dB typ pF typ pF typ pF typ | $\mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}$ <br> $\mathrm{V}_{\mathrm{S}}=+1 \mathrm{~V}$; Test Circuit 4 <br> $\mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}$; <br> $\mathrm{V}_{\mathrm{S}}=+1 \mathrm{~V}$; Test Circuit 4 <br> $\mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}$; <br> $\mathrm{V}_{\mathrm{S} 1}=\mathrm{V}_{\mathrm{S} 2}=+1 \mathrm{~V}$; Test Circuit 5 <br> $\mathrm{V}_{\mathrm{S}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{S}}=0 \Omega, \mathrm{C}_{\mathrm{L}}=10 \mathrm{nF}$; <br> Test Circuit 6 <br> $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{f}=1 \mathrm{MHz}$; <br> Test Circuit 7 $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{f}=1 \mathrm{MHz}$ <br> Test Circuit 8 <br> $\mathrm{f}=1 \mathrm{MHz}$ <br> $\mathrm{f}=1 \mathrm{MHz}$ <br> $\mathrm{f}=1 \mathrm{MHz}$ |
| POWER REQUIREMENTS $\mathrm{V}_{\mathrm{DD}}$ $\mathrm{I}_{\mathrm{DD}}$ | 0.0001 | $\begin{aligned} & 3 / 3.6 \\ & 1 \\ & \hline \end{aligned}$ | V min/max $\mu \mathrm{A}$ typ $\mu \mathrm{A}$ max | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=+3.6 \mathrm{~V} \\ & \text { Digital Inputs }=0 \mathrm{~V} \text { or } 3 \mathrm{~V} \end{aligned}$ |

## NOTES

${ }^{1}$ Temperature range is as follows: B Version $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$.
${ }^{2}$ Guaranteed by design, not subject to production test.
Specifications subject to change without notice.

## ADG511/ADG512/ADG513

ABSOLUTE MAXIMUM RATINGS*
$\left(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right.$ unless otherwise noted)
$\mathrm{V}_{\mathrm{DD}}$ to $\mathrm{V}_{\text {ss }}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . +44 V

$V_{\text {ss }}$ to GND ..... +0.3 V to -25 V
Analog, Digital Inputs ${ }^{1} \ldots \ldots V_{\text {ss }}-2 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}+2 \mathrm{~V}$ or30 mA , whichever occurs first
Continuous Current, S or D ..... 30 mA
Peak Current, S or D ..... 100 mA
(Pulsed at $1 \mathrm{~ms}, 10 \%$ Duty Cycle max)
Operating Temperature Range
Industrial (B Version) . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Extended (T Version) . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Junction Temperature ..... $+150^{\circ} \mathrm{C}$
Cerdip Package, Power Dissipation ..... 900 mW
$\theta_{\mathrm{JA}}$ Thermal Impedance ..... $76^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature, Soldering ( 10 sec ) ..... $+300^{\circ} \mathrm{C}$
Plastic Package, Power Dissipation ..... 470 mW
$\theta_{\mathrm{JA}}$ Thermal Impedance ..... $117^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature, Soldering ( 10 sec ) ..... $+260^{\circ} \mathrm{C}$
SOIC Package, Power Dissipation ..... 600 mW
$\theta_{\mathrm{JA}}$ Thermal Impedance ..... $77^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature, Soldering
Vapor Phase ( 60 sec ) ..... $+215^{\circ} \mathrm{C}$
Infrared ( 15 sec ) ..... $+220^{\circ} \mathrm{C}$

## NOTES

*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Only one absolute maximum rating may be applied at any one time.
${ }^{1}$ Overvoltages at IN, S or D will be clamped by internal diodes. Current should be limited to the maximum ratings given.

## ESD SUSCEPTIBILITY

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 volts, which readily accumulate on the human body and on test equipment, can discharge without detection. Although the ADG511/ADG512/ADG513 features proprietary ESD protection circuitry, permanent damage may still occur on these devices if they are subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid any
 performance degradation or loss of functionality.

## ORDERING GUIDE

| Model $^{\mathbf{1}}$ | Temperature Range ${ }^{\mathbf{2}}$ | Package Option |
| :--- | :--- | :--- |
| ADG511BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| ADG511BR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16 \mathrm{~A}$ |
| ADG511TQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| ADG512BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| ADG512BR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16 \mathrm{~A}$ |
| ADG512TQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| ADG513BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| ADG513BR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16 \mathrm{~A}$ |

## NOTES

${ }^{1}$ To order MIL-STD-883, Class B processed parts, add /883B to T grade part numbers.
${ }^{2} 3.3 \mathrm{~V}$ specifications apply over $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ temperature range.
${ }^{3} \mathrm{~N}=$ Plastic DIP; $\mathrm{R}=0.15^{\prime \prime}$ Small Outline IC (SOIC); Q = Cerdip. For outline information see Package Information section.

## PIN CONFIGURATION (DIP/SOIC)



Truth Table (ADG511/ADG512)

| ADG511 <br> In | ADG512 <br> In | Switch <br> Condition |
| :--- | :--- | :--- |
| 0 | 1 | ON |
| 1 | 0 | OFF |

Truth Table (ADG513)

|  | Switch | Switch |
| :--- | :--- | :--- |
| Logic | 1,4 | 2,3 |
| 0 | OFF | ON |
| 1 | ON | OFF |

## TERMINOLOGY

| $\mathrm{V}_{\text {DD }}$ | Most positive power supply potential. |
| :---: | :---: |
| $\mathrm{V}_{\text {ss }}$ | Most negative power supply potential in dual supplies. In single supply applications, it may be connected to GND. |
| GND | Ground ( 0 V ) reference. |
| S | Source terminal. May be an input or output. |
| D | Drain terminal. May be an input or output. |
| IN | Logic control input. |
| $\mathrm{R}_{\mathrm{ON}}$ | Ohmic resistance between D and S. |
| $\mathrm{I}_{\text {S }}$ (OFF) | Source leakage current with the switch "OFF." |
| $\mathrm{I}_{\mathrm{D}}$ (OFF) | Drain leakage current with the switch "OFF." |
| $\mathrm{I}_{\mathrm{D}}, \mathrm{I}_{\mathrm{S}}(\mathrm{ON})$ | Channel leakage current with the switch "ON." |
| $\mathrm{V}_{\mathrm{D}}\left(\mathrm{V}_{\mathrm{s}}\right)$ | Analog voltage on terminals D, S. |
| $\mathrm{C}_{\mathrm{S}}$ (OFF) | "OFF" switch source capacitance. |
| $\mathrm{C}_{\mathrm{D}}$ (OFF) | "OFF" switch drain capacitance. |
| $\mathrm{C}_{\mathrm{D}}, \mathrm{C}_{\mathrm{S}}(\mathrm{ON})$ | "ON" switch capacitance. |
| $\mathrm{t}_{\mathrm{ON}}$ | Delay between applying the digital control input and the output switching on. |
| $\mathrm{t}_{\text {OFF }}$ | Delay between applying the digital control input and the output switching off. |
| $t_{\text {D }}$ | "OFF" or "ON" time measured between the $90 \%$ points of both switches when switching from one address state to another. |
| Crosstalk | A measure of unwanted signal which is coupled through from one channel to another as a result of parasitic capacitance. |
| Off Isolation | A measure of unwanted signal coupling through an "OFF" switch. |
| Charge Injection | A measure of the glitch impulse transferred from the digital input to the analog output during switching. |

## ADG511/ADG512/ADG513-Typical Performance Graphs



Figure 1. On Resistance as a Function of $V_{D}\left(V_{S}\right)$ Dual Supplies


Figure 2. On Resistance as a Function of $V_{D}\left(V_{S}\right)$ for Different Temperatures


Figure 3. On Resistance as a Function of $V_{D}\left(V_{S}\right)$ Single Supply


Figure 4. Supply Current vs. Input Switching Frequency


Figure 5. Leakage Currents as a Function of Temperature


Figure 6. Off Isolation vs. Frequency


Figure 7. Leakage Currents as a Function of $V_{D}\left(V_{S}\right)$


Figure 8. Crosstalk vs. Frequency

## ADG511/ADG512/ADG513

## TRENCH ISOLATION

In the ADG511/ADG512/ADG513, an insulating oxide layer (trench) is placed between the NMOS and the PMOS transistors of each CMOS switch. Parasitic junctions, which occur between the transistors in Junction Isolated switches, are eliminated. The result is a completely latch-up proof switch.
In Junction Isolation, the $\mathbf{N}$ and $\mathbf{P}$ wells of the PMOS and NMOS transistors form a diode which is reverse-biased under normal operation. However, during overvoltage conditions, this diode becomes forward biased. A Silicon-Controlled Rectifier (SCR) type circuit is formed by the two transistors causing a significant amplification of the current which, in turn, leads to latch-up. With Trench Isolation, this diode is removed, the result being a latch-up proof switch.

Trench Isolation also leads to lower leakage currents. The ADG511/ADG512/ADG513 has a leakage current of 0.1 nA as compared with a leakage current of several nanoamps in nonTrench Isolated switches. Leakage current is an important parameter in sample-and-hold circuits, this current being responsible for the discharge of the holding capacitor with time causing droop. The ADG511/ADG512/ADG513's low leakage current, along with its fast switching speeds, make it suitable for fast and accurate sample-and-hold circuits.


Figure 9. Trench Isolation

## APPLICATION

Figure 10 illustrates a precise sample-and-hold circuit. An AD845 is used as the input buffer while the output operational amplifier is an OP-07. During the track mode, SW1 is closed and the output $\mathrm{V}_{\text {OUt }}$ follows the input signal $\mathrm{V}_{\mathrm{IN}}$. In the hold mode, SW1 is opened and the signal is held by the hold capacitor $\mathrm{C}_{\mathrm{H}}$.
Due to switch and capacitor leakage, the voltage on the hold capacitor will decrease with time. The ADG511/ADG512/ ADG513 minimizes this droop due to its low leakage specifications. The droop rate is further minimized by the use of a polystyrene hold capacitor. The droop rate for the circuit shown is typically $15 \mu \mathrm{~V} / \mu \mathrm{s}$.
A second switch SW2, which operates in parallel with SW1, is included in this circuit to reduce pedestal error. Since both switches will be at the same potential, they will have a differential effect on the op amp OP-07 which will minimize charge injection effects. Pedestal error is also reduced by the compensation network $\mathrm{R}_{\mathrm{C}}$ and $\mathrm{C}_{\mathrm{C}}$. This compensation network also reduces the hold time glitch while optimizing the acquisition time. Using the illustrated op amps and component values, the pedestal error has a maximum value of 5 mV over the $\pm 3 \mathrm{~V}$ input range. The acquisition time is $2.5 \mu \mathrm{~s}$ while the settling time is $1.85 \mu \mathrm{~s}$.


Figure 10. Accurate Sample-and-Hold

# 8-Chan/Dual 4-Chan JFET Analog Multiplexers (Overvoltage \& Power Supply Loss Protected) 

## MUX08/MUX24

## FEATURES

- JFET Switches Rather Than CMOS
- Low "ON" Resistance
$220 \Omega$ Typ
- Highly Resistant to Static Discharge Damage
- No SCR Latch-Up Problems
- Digital Inputs Compatible With TTL and CMOS
- $125^{\circ}$ C Temperature Tested Dice Available
- MUX-08 Pin Compatible With DG508, HI-508A, IH5108, IH6108, LF11508/12508/13508, AD7506
- MUX-24 Pin Compatible With DG509, HI-509A, IH5208, IH6208, LF11509/12509/13509, AD7507
- Available in Surface Mount Packages
- Available in Die Form


## ORDERING INFORMATION ${ }^{\dagger}$

| PACKAGE |  |  |  | OPERATING TEMPERATURE RANGE |
| :---: | :---: | :---: | :---: | :---: |
| $25^{\circ} \mathrm{CON}$ RESISTANCE | $\begin{aligned} & \text { CERDIP } \\ & \text { 16-PIN } \end{aligned}$ | PLASTIC 16-PIN | $\begin{gathered} \text { LCC } \\ 20-C O N T A C T \end{gathered}$ |  |
|  | MUX08AQ* | - | - | MIL |
| $220 \Omega$ | MUX08EQ | - | - | IND |
|  | - | MUX08EP | - | COM |
|  | MUXO8BQ* | - | MUX08BRC/883 | MIL |
| $300 \Omega$ | MUX08FQ | - | - | IND |
|  | - | MUX08FP | - | XIND |
|  | - | MUX08FS ${ }^{\text {+ }}$ | - | XIND |
|  | MUX24AQ* | - | - | MIL |
| $220 \Omega$ | MUX24EQ | - | - | IND |
|  | - | MUX24EP | - | COM |
|  | MUX24BQ* | - | - | MIL |
| 3008 | MUX24FQ | - | - | IND |
| $300 \Omega$ | - | MUX24FP | - | XIND |
|  | - | MUX24FS ${ }^{\text {H }}$ | - | XIND |

- For devices processed in total compliance to MIL-STD-883, add /883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.
H For availability and burn-in information on SO and PLCC packages, contact your local sales office.


## GENERAL DESCRIPTION

The MUX-08 is a monolithic eight-channel analog multiplexer which connects a single output to one of the eight analog inputs depending upon the state of a 3-bit binary address.

The MUX-24 is a monolithic four-channel differential analog multiplexer configured in a double pole, four-position (plus OFF) electronic switch array. A two-bit binary input address connects a pair of independent analog inputs from each four-channel input section to the corresponding pair of independent analog outputs.

All switches in the MUX-08/MUX-24 are turned OFF by applying logic " 0 " to the ENABLE pin, thereby providing a package select function.

Fabricated with Precision Monolithics' high performance Bipolar-JFET technology, these devices offer low, constant "ON" resistance, low leakage currents and fast settling time with low crosstalk to satisfy a wide variety of applications. These multiplexers do not suffer from latch-up or static charge blow-out problems associated with similar CMOS parts. The digital inputs are designed to operate from both TTL and CMOS levels while always providing a definite break-before-make action without the need for external pullup resistors over the full operating temperature range.
For single sixteen-channel and dual eight-channel models, refer to the MUX-16/MUX-28 data sheet.

## PIN CONNECTIONS



16-PIN CERDIP (Q-Suffix)
16-PIN PLASTIC DIP (P-Suffix) 16-PIN SO (S-Suffix)

20-CONTACT LCC (RC-Suffix)


FUNCTIONAL DIAGRAMS


## MUX08/MUX24



Analog Input Voltage ....... V-Supply -20V to V+ Supply +20 V Maximum Current Through Any Pin ............................... 25mA

| PACKAGE TYPE | $\Theta_{j A}$ (Note 2) | $\theta_{\text {jc }}$ | UNITS |
| :---: | :---: | :---: | :---: |
| 16 -Pin Hermetic DIP (Q) | 100 | 16 | ${ }^{\circ} \mathrm{C}$ N |
| 16 -Pin Plastic DIP (P) | 82 | 39 | ${ }^{\circ} \mathrm{CN}$ |
| 20-Contact LCC (RC) | 98 | 38 | ${ }^{\circ} \mathrm{CN}$ |
| 16 -Pin SO(S) | 111 | 35 | ${ }^{\circ} \mathrm{CN}$ |

## NOTES:

1. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
2. $\Theta_{\mathrm{ja}}$ is specified for worst case mounting conditions, i.e., $\boldsymbol{\Theta}_{\mathrm{j} A}$ is specified for device in socket for CerDIP, P-DIP, and LCC packages; $\Theta_{j A}$ is specified for device soldered to printed circuit board for SO package.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}+=+15 \mathrm{~V}, \mathrm{~V}-=-15 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS |  | MUX-08A/E MUX-24A/E |  |  | MUX-08B/F MUX-24B/F |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | MIN | TYP | MAX | MIN | TYP | MAX |  |
| "ON" Resistance | $\mathrm{R}_{\mathrm{ON}}$ | $\mathrm{V}_{\mathrm{S}} \leq 10 \mathrm{~V}_{\text {, }} \mathrm{I}_{\text {S }} \leq 200 \mu \mathrm{~A}$ |  | - | 220 | 300 | - | 300 | 400 | $\Omega$ |
| $\Delta \mathrm{R}_{\text {ON }}$ With Applied Voltage | $\Delta R_{\text {ON }}$ | $-10 \mathrm{~V} \leq \mathrm{V}_{S} \leq 10 \mathrm{~V}, \mathrm{I}_{S}=200 \mu \mathrm{~A}$ |  | - | 1 | 5 | - | 3 | 7 | \% |
| $\mathrm{R}_{\text {ON }}$ Match Between Switches | R ${ }_{\text {ON }}$ Match | $\mathrm{V}_{\mathrm{S}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=200 \mu \mathrm{~A}$ |  | - | 7 | 15 | - | 9 | 20 | \% |
| Analog Voltage Range | $\mathrm{V}_{\mathrm{A}}$ | (Note 6) |  | $\begin{aligned} & +10 \\ & -10 \end{aligned}$ | $\begin{array}{r} +10.4 \\ -15 \end{array}$ | - | $\begin{array}{r} +10 \\ -10 \end{array}$ | $\begin{array}{r} +10.4 \\ -15 \end{array}$ | - | V |
| Source Current (Switch "OFF") | Is, OFF, | $\mathrm{V}_{\mathrm{S}}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{D}}=-10 \mathrm{~V}$ (Note 1) |  | - | 0.01 | 1.0 | - | 0.01 | 2.0 | nA |
| Drain Current (Switch "OFF") | ID OFF, | $V_{S}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{D}}=-10 \mathrm{~V}$ (Note 1) | $\begin{aligned} & \text { MUX-08 } \\ & \text { MUX-24 } \end{aligned}$ | - | $\begin{array}{r} 0.1 \\ 0.05 \end{array}$ | 1.0 1.0 | - | $\begin{array}{r} 0.1 \\ 0.05 \end{array}$ | $\begin{aligned} & 2.0 \\ & 2.0 \end{aligned}$ | nA |
| Leakage Current (Switch "ON") | $\begin{aligned} & I_{D} \text { ON } \\ & +I_{S, O N} \\ & \hline \end{aligned}$ | $\mathrm{V}_{\mathrm{D}}=10 \mathrm{~V}$ (Note 1) | $\begin{aligned} & \text { MUX-08 } \\ & \text { MUX-24 } \end{aligned}$ | - | $\begin{array}{r} 0.1 \\ 0.05 \\ \hline \end{array}$ |  | - | $\begin{array}{r} 0.1 \\ 0.05 \\ \hline \end{array}$ | $\begin{aligned} & 2.0 \\ & 2.0 \end{aligned}$ | $n \mathrm{~A}$ |
| Digital Input Current | $\mathrm{I}_{\text {IN }}$ | $\mathrm{V}_{\text {IN }}=0.4 \mathrm{~V}$ to 15 V |  | - | 1 | 10 | - | 1 | 10 | $\mu \mathrm{A}$ |
| Digital "0" Enable Current | $\mathrm{I}_{\text {INL, EN }}$ | $\mathrm{V}_{\mathrm{EN}}=0.4 \mathrm{~V}$ |  | - | 4 | 10 | - | 4 | 10 | $\mu \mathrm{A}$ |
| Digital Input Capacitance | $\mathrm{C}_{\text {DIG }}$ |  |  | - | 3 | - | - | 3 | - | pF |
| Switching Time (ttran) | $t_{\text {PHL }}$ $t_{\text {PLH }}$ | (Notes 2, 5) Figure 1 (Test Circuit) |  | - | 1.5 1.0 | 2.1 <br> 1.3 | - | $\begin{aligned} & 1.5 \\ & 1.0 \\ & \hline \end{aligned}$ | $\begin{aligned} & 2.1 \\ & 1.3 \end{aligned}$ | $\mu \mathrm{S}$ |
| Output Settling Time | $\mathrm{t}_{5}$ | 10 V Step to $0.10 \%$ <br> 10 V Step to $0.05 \%$ <br> 10 V Step to $0.02 \%$ |  | - | 2.2 2.7 3.4 | - | - | 2.2 2.7 3.4 | - | $\mu \mathrm{S}$ |
| Break-Before-Make Delay | $\mathrm{t}_{\text {OPEN }}$ | Figure 3 (Test Circuit) |  | - | 0.8 | - | - | 1.0 | - | $\mu \mathrm{s}$ |
| Enable Delay "ON" | ton EN, | (Note 5) Figure 2 (Test Circuit) |  | - | 1 | 2 | - | 1 | 17 2 | $\mu \mathrm{S}$ |
| Enable Delay "OFF" | toff (EN) | (Note 5) Figure 2 (Test Circuit) | $\begin{aligned} & \text { MUX-08 } \\ & \text { MUX-24 } \end{aligned}$ | - | $\begin{aligned} & 0.1 \\ & 0.2 \end{aligned}$ | $\begin{aligned} & 0.4 \\ & 0.5 \end{aligned}$ | $-$ | $\begin{aligned} & 0.2 \\ & 0.3 \end{aligned}$ | $\begin{aligned} & 0.4 \\ & 0.6 \end{aligned}$ | $\mu \mathrm{S}$ |
| "OFF" Isolation | $\mathrm{ISO}_{\text {OFF }}$ | (Note 4) Figure 5 (Test Circuit) | $\begin{aligned} & \text { MUX-08 } \\ & \text { MUX-24 } \end{aligned}$ | - | $\begin{array}{r} 60 \\ 66 \end{array}$ | - | - | $\begin{aligned} & 60 \\ & 66 \end{aligned}$ | - | dB |
| Crosstalk | CT | (Note 3) Figure 4 (Test Circuit) | $\begin{aligned} & \text { MUX-08 } \\ & \text { MUX-24 } \end{aligned}$ | - | $\begin{array}{r} 70 \\ 76 \\ \hline \end{array}$ | - | - | $\begin{aligned} & 70 \\ & 76 \end{aligned}$ | - | dB |
| Source Capacitance | $\mathrm{C}_{\text {S OfF, }}$ | Switch "OFF", $\mathrm{V}_{\mathrm{S}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{D}}=0 \mathrm{~V}$ | $\begin{aligned} & \text { MUX-08 } \\ & \text { MUX-24 } \end{aligned}$ | - | $\begin{array}{r} 2.5 \\ 2 \end{array}$ | - | - | $\begin{array}{r} 2.5 \\ 2 \end{array}$ | - | pF |
| Drain Capacitance | $C_{\text {dioff }}$ | Switch "OFF", $V_{S}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{D}}=0 \mathrm{~V}$ | $\begin{aligned} & \text { MUX-08 } \\ & \text { MUX-24 } \end{aligned}$ | - | 7 4 | - | - | 7 4 | - | pF |
| Input to Output Capacitance | $\mathrm{C}_{\text {dSioff }}$ | (Note 4) | $\begin{aligned} & \text { MUX-08 } \\ & \text { MUX-24 } \end{aligned}$ | - | $\begin{array}{r} 0.3 \\ 0.15 \end{array}$ | - | - | $\begin{array}{r} 0.3 \\ 0.15 \end{array}$ | - | pF |
| Positive Supply Current (All Digital Inputs Logic " 0 " or "1") | $1+$ | $\begin{aligned} & \mathrm{V}+=15 \mathrm{~V} \\ & \mathrm{~V}+=5 \mathrm{~V} \end{aligned}$ |  | - | 10 8 | 12 | - | 6 5 | 12 | - mA |
| Negative Supply Current <br> (All Digital Inputs <br> Logic "0" or "1") | 1- | $\begin{aligned} & V+=-15 V \\ & V+=-5 V \end{aligned}$ |  | - | 3.0 2.5 | 3.8 | - | $\begin{aligned} & 2.0 \\ & 1.8 \end{aligned}$ | 3.8 - | mA |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}+=15 \mathrm{~V}, \mathrm{~V}-=-15 \mathrm{~V}$ and $-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq 125^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS |  | $\begin{aligned} & \text { MUX-08A } \\ & \text { MUX-24A } \end{aligned}$ |  |  | MUX-08B/ MUX-24B |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | MIN | TYP | MAX | MIN | TYP | MAX |  |
| "ON" Resistance | $\mathrm{R}_{\text {ON }}$ | $\mathrm{V}_{S} \leq 10 \mathrm{~V}, \mathrm{I}_{\mathrm{S}} \leq 200 \mu \mathrm{~A}$ |  | - | - | 400 | - | - | 500 | $\Omega$ |
| $\Delta \mathrm{R}_{\text {ON }}$ With Applied Voltage | $\Delta \mathrm{R}_{\text {ON }}$ | $-10 \mathrm{~V} \leq \mathrm{V}_{\mathrm{S}} \leq 10 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=200 \mu \mathrm{~A}$ |  | - | 1.5 | - | - | 4.5 | - | \% |
| $\mathrm{R}_{\text {ON }}$ Match Between Switches | $\mathrm{R}_{\text {ON }}$ Match | $\mathrm{V}_{\mathrm{S}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=200 \mu \mathrm{~A}$ |  | - | 10 | - | - | 15 | - | \% |
| Analog Voltage Range | $\mathrm{V}_{\text {A }}$ | (Note 6) |  |  | $\begin{array}{r} +10.4 \\ -15 \end{array}$ | - | $\begin{aligned} & +10 \\ & -10 \end{aligned}$ | $\begin{array}{r} +10.4 \\ -15 \end{array}$ | - | V |
| Source Current (Switch "OFF") | $\mathrm{I}_{\text {S ( OFF) }}$ | $\mathrm{V}_{\mathrm{S}}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{D}}=-10 \mathrm{~V}$ (Notes 1, 7) |  | - | - | 25 | - | - | 50 | nA |
| Drain Current (Switch "OFF") | $\mathrm{I}_{\mathrm{D} \text { ( } \mathrm{OFF} \text { ) }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{D}}=-10 \mathrm{~V} \\ & (\text { Notes } 1,7) \end{aligned}$ | $\begin{aligned} & \text { MUX-08 } \\ & \text { MUX-24 } \end{aligned}$ | - | - | $\begin{array}{r} 100 \\ 50 \end{array}$ | - | - | $\begin{aligned} & 500 \\ & 500 \end{aligned}$ | nA |
| Leakage Current (Switch "ON") | $\begin{aligned} & I_{\mathrm{D}(\mathrm{ON})} \\ & +\mathrm{I}_{\mathrm{S}(\mathrm{ON})} \end{aligned}$ | $V_{D}=10 \mathrm{~V}$ (Notes 1, 7 ) | $\begin{aligned} & \text { MUX-08 } \\ & \text { MUX-24 } \end{aligned}$ | - | - | $\begin{array}{r} 100 \\ 50 \end{array}$ | - | - | $\begin{aligned} & 500 \\ & 500 \end{aligned}$ | nA |
| Digital "1" Input Voltage | $\mathrm{V}_{\text {INH }}$ | (Note 6) |  | 2 | - | - | 2 | - | - | V |
| Digital "0" Input Voltage | $\mathrm{V}_{\text {INL }}$ | (Note 6) |  | - | - | 0.7 | - | - | 0.7 | V |
| Digital Input Current | $\mathrm{I}_{\text {IN }}$ | $\mathrm{V}_{\text {IN }}=0.4 \mathrm{~V}$ to 15 V |  | - | - | 20 | - | - | 20 | $\mu \mathrm{A}$ |
| Digital "0" Enable Current | $\mathrm{I}_{\text {INL (EN) }}$ | $\mathrm{V}_{\mathrm{EN}}=0.4 \mathrm{~V}$ |  | - | - | 20 | - | - | 20 | $\mu \mathrm{A}$ |
| Positive Supply Current | I+ | All Digital Inputs Logic "0" or "1" |  | - | - | 15 | - | - | 15 | mA |
| Negative Supply Current | $1-$ | All Digital Inputs Logic " 0 " or " 1 " |  | - | - | 5 | - | - | 5 | mA |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{+}=15 \mathrm{~V}, \mathrm{~V}-=-15 \mathrm{~V}$ and $-25^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}}+85^{\circ} \mathrm{C}$ for MUX-08EQ/FQ and MUX-24EQ/FQ; $0^{\circ} \mathrm{C} \leq T_{A} \leq+70^{\circ} \mathrm{C}$ for MUX-08EP and MUX-24EP; $-40^{\circ} \mathrm{C} \leq T_{A} \leq+85^{\circ} \mathrm{C}$ for MUX-08FP/FS and MUX-24FP/FS, unless otherwise noted.

|  |  | : |  |  | $\begin{aligned} & \text { UX-08 } \\ & \text { IUX-2 } \end{aligned}$ |  |  | UX-O IUX-2 |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PARAMETER | SYMBOL | CONDITIONS |  | MIN | TYP | MAX | MIN | TYP | MAX | UNITS |
| "ON" Resistance | $\mathrm{R}_{\mathrm{ON}}$ | $\mathrm{V}_{\mathrm{S}} \leq 10 \mathrm{~V}, \mathrm{I}_{\mathrm{S}} \leq 200 \mu \mathrm{~A}$ |  | - | - | 400 | - | - | 500 | $\Omega$ |
| $\Delta \mathrm{R}_{\text {ON }}$ With Applied Voltage | $\Delta \mathrm{R}_{\text {ON }}$ | $-10 \mathrm{~V} \leq \mathrm{V}_{S} \leq 10 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=200 \mu \mathrm{~A}$ |  | - | 1.5 | - | - | 4.5 | - | \% |
| $\mathrm{R}_{\text {ON }}$ Match Between Switches | $\mathrm{R}_{\text {ON }}$ Match | $\mathrm{V}_{\mathrm{S}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=200 \mu \mathrm{~A}$ |  | - | 10 | - | - | 15 | - | \% |
| Analog Voltage Range | $\mathrm{V}_{\mathrm{A}}$ | (Note 6) |  |  | $\begin{array}{r} +10.4 \\ -15 \end{array}$ | - | +10 -10 | $\begin{array}{r} +10.4 \\ -15 \end{array}$ | - | V |
| Source Current (Switch "OFF") | $\mathrm{I}_{\text {S ( OFF) }}$ | $\mathrm{V}_{S}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{D}}=-10 \mathrm{~V}$ (Notes 1, 7) |  | - | - | 10 | - | - | 10 | nA |
| Drain Current (Switch "OFF") | ${ }^{\text {d }}$ ( OFF) | $V_{S}=10 \mathrm{~V}, V_{D}=-10 \mathrm{~V}$ <br> (Notes 1, 7) | MUX-08 <br> MUX-24 | - | - | $\begin{array}{r} 100 \\ 50 \\ \hline \end{array}$ | - | - | $\begin{array}{r} 100 \\ 50 \end{array}$ | nA |
| Leakage Current (Switch "ON") | $\begin{aligned} & I_{D(O N)} \\ & +I_{S}(O N) \\ & \hline \end{aligned}$ | $V_{D}=10 \mathrm{~V}$ ( Notes 1, 7) | MUX-08 <br> MUX-24 | - | - | $\begin{array}{r} 100 \\ 50 \end{array}$ | - | - | $\begin{array}{r} 100 \\ 50 \end{array}$ | nA |
| Digital "1" Input Voltage | $V_{\text {INH }}$ | (Note 6) |  | 2 | - | - | 2 | - | - | V |
| Digital "0" Input Voltage | $\mathrm{V}_{\text {INL }}$ | (Note 6) |  | - | - | 0.8 | - | - | 0.8 | V |
| Digital Input Current | $\mathrm{I}_{\text {N }}$ | $\mathrm{V}_{\text {IN }}=0.4 \mathrm{~V}$ to 15 V |  | - | - | 20 | - | - | 20 | $\mu \mathrm{A}$ |
| Digital "0" Enable Current | $\mathrm{I}_{\text {INL (EN) }}$ | $\mathrm{V}_{\mathrm{EN}}=0.4 \mathrm{~V}$ |  | - | - | 20 | - | - | 20 | $\mu \mathrm{A}$ |
| Positive Supply Current | I+ | All Digital Inputs Logic " 0 " or " 1 " |  | - | - | 15 | - | - | 15 | mA |
| Negative Supply Current | 1- | All Digital Inputs Logic " 0 " or " 1 " |  | - | - | 5 | - | - | 5 | mA |
| Conditions applied to leakage tests insure worst case leakages. Exceeding 11 V on the analog input may cause an "OFF" channel to turn "ON". |  |  | 4. "OFF" isolation is measured by driving channel 8 with ALL channels "OFF". $R_{L}=1 \mathrm{k} \Omega, C_{L}=10 \mathrm{pF}, \mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}$ RMS, $\mathrm{f}=500 \mathrm{kHz}$. $\mathrm{C}_{\mathrm{DS}}$ is computed from the OFF isolation measurement. |  |  |  |  |  |  |  |
| 3. Crosstalk is measured by driving channel 8 with channel 4 "ON". $R_{L}=1 M \Omega, C_{L}=10 \mathrm{pF}, \mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}$ RMS, $\mathrm{f}=500 \mathrm{kHz}$. |  |  | 6. Guaranteed by leakage current and $R_{\text {ON }}$ tests. <br> 7. Leakage tests are performed only on military temperature grades at $125^{\circ} \mathrm{C}$. |  |  |  |  |  |  |  |

## FEATURES

- JFET Switches Rather Than CMOS
- Highly Resistant To Static Discharge Damage
- No SCR Latch-up Problems
- Low "ON" Resistance - 290 2 Typical
- Low Leakage Current
- Digital Inputs Compatible With TTL and CMOS
- Break-Before-Make Action
- $125^{\circ}$ C Temperature-Tested Dice Avallable
- Overvoltage Protected
- Supply Loss Protection
- MUX-16 Pin Compatible With DG506, HI-506A, AD7506
- MUX-28 Pin Compatible With DG507, HI-507A, AD7507
- Available in Die Form


## ORDERING INFORMATION ${ }^{\dagger}$

| $\begin{gathered} 25^{\circ} \mathrm{C} \\ \text { RESISTANCE } \end{gathered}$ | PaCKAGE |  |  | operating TEMPERATURE RANGE |
| :---: | :---: | :---: | :---: | :---: |
|  | CERDIP <br> 28-PIN | $\begin{gathered} \text { LCC } \\ 28-C O N T A C T \end{gathered}$ | PLASTIC 28-PIN |  |
| 2908 | MUX16AT* | - | - | MIL |
| 2908 | MUX16ET | - | - | IND |
| 400, | MUX16BT* | MUX16BTC/883 | - | MIL |
| 4008 | MUX16FT | - - | MUX16FP | XIND |
| 4008 | - | - | MUX16FPC | XIND |
| 2908 | MUX28AT* | - | - | MIL |
| 2908 | MUX28ET | - | - | IND |
| 4008 | MUX28BT* | MUX28BTC/883 | - | MLL |
| 4008 | MUX28FT | - | MUX28FP | XIND |
| 400, | - | - | MUX28FPC | XIND |

- For devices processed in total compliance to MIL-STD-883, add /883 after part number. Consult factory for 883 data sheet.
t Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.


## FUNCTIONAL DIAGRAMS



## GENERAL DESCRIPTION

The MUX-16 is a monolithic 16 -channel analog multiplexer which connects a single output to 1 of the 16 analog inputs depending upon the state of a 4-bit binary address. Disconnection of the output is provided by a logical " 0 " at the ENABLE input, thereby providing a package selection function.

The MUX-28 is a monolithic 8-channel differential analog multiplexer configured in a double pole, 8-position (plus OFF) electronic switch array. A 3-bit binary input address connects a pair of independent analog inputs from each 8-channel input section to the corresponding pair of independent analog outputs. Disconnection of both inputs is provided by a logical " 0 " at the ENABLE input, thereby offering a package select function.
Fabricated with Precision Monolithics' high performance Bipolar-JFET technology, these devices offer low, constant "ON" resistance. Performance advantages include low leakage currents and fast settling time with low crosstalk to satisfy a wide variety of applications. These multiplexers do not suffer from latch-up or static discharge blow-out problems associated with similar CMOS parts. The digital inputs are designed to operate from both TTL and CMOS levels while always providing a definite break-before-make action without the need for external pull-up resistors. For single 8 -channel and dual 4 -channel models, refer to the MUX-08/MUX-24 data sheet.


This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

PIN CONNECTIONS \& TRUTH TABLES


## ABSOLUTE MAXIMUM RATINGS (Note 1)

| Operating Temperature Range, |
| :---: |
| MUX-16/28-AT, BT, BTC ........................ -55 ${ }^{\circ} \mathrm{C}$ to +12 |
| MUX |
| MUX-16/28-FP, FPC, FT ......................... $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Junction Temperature (T).......................... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Storage Temperature Range ..................... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Lead Temperature (Soldering, 60 sec ) ....................... $300^{\circ} \mathrm{C}$ |
| Maximum Junction Temperature .............................. $150^{\circ} \mathrm{C}$ |
| V+Supply to V-Supply ............................................ 36V |
| Logic Input Voltage ........................ (V- or -4V) to V+Supply |
| Analog Input Voltage ....... V-Supply -20V to V+ Supply |



## NOTES:

1. Ratings apply to both DICE and packaged parts, unless otherwise noted.
2. $\Theta_{j A}$ is specified for worst case mounting conditions, i.e., $\boldsymbol{\Theta}_{\mathrm{jA}}$ is specified for device in socket for CerDIP, P-DIP, and LCC packages; $\Theta_{j A}^{j A}$ is specified for device soldered to printed circuit board for PLCC package.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS |  | $\begin{aligned} & \text { MUX-16A/E } \\ & \text { MUX-28A/E } \end{aligned}$ |  |  | $\begin{aligned} & \text { MUX-16B/F } \\ & \text { MUX-28B/F } \end{aligned}$ |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | UNITS |
| "ON" Resistance | $\mathrm{R}_{\text {ON }}$ | $\mathrm{V}_{\mathrm{S}} \leq 10 \mathrm{~V}, \mathrm{I}_{\mathrm{S}} \leq 200 \mu \mathrm{~A}$ |  | - | 290 | 380 | - | 400 | 580 | $\Omega$ |
| $\Delta \mathrm{R}_{\text {ON }}$ With Applied Voltage | $\Delta \mathrm{R}_{\text {ON }}$ | $-10 \mathrm{~V} \leq \mathrm{V}_{S} \leq 10 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=200 \mu \mathrm{~A}$ |  | - | 1.5 | 5 | - | 1.5 | 5 | \% |
| $\mathrm{R}_{\text {ON }}$ Match Between Switches | $\mathrm{R}_{\text {ON }}$ Match | $\mathrm{V}_{\mathrm{S}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=200 \mu \mathrm{~A}$ |  | - | 7 | 15 | - | 9 | 20 | \% |
| Analog Voltage Range | $V_{\text {A }}$ | (Note 6) |  | $\begin{array}{r} +10 \\ -10 \end{array}$ | $\begin{aligned} & +11 \\ & -15 \end{aligned}$ | - | $\begin{aligned} & +10 \\ & -10 \end{aligned}$ | $\begin{aligned} & +11 \\ & -15 \end{aligned}$ | - | V |
| Source Current (Switch "OFF") | $\mathrm{IS}_{\text {( }}$ OFF) | $\mathrm{V}_{\mathrm{S}}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{D}}=-10 \mathrm{~V}$ (Note 1) |  | - | 0.01 | 1 | - | 0.01 | 2 | nA |
| Drain Current (Switch "OFF") | $I_{\text {d }}$ (OFF) | $\mathrm{V}_{\mathrm{S}}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{D}}=-10 \mathrm{~V}$ (Note 1) | $\begin{aligned} & \text { MUX-16 } \\ & \text { MUX-28 } \end{aligned}$ | - | $\begin{aligned} & 0.2 \\ & 0.1 \end{aligned}$ | 1 1 | - | $\begin{aligned} & 0.2 \\ & 0.1 \end{aligned}$ | $\begin{aligned} & 2 \\ & 2 \end{aligned}$ | nA |
| Leakage Current (Switch "ON") | $\begin{aligned} & \mathrm{I}_{\mathrm{D}}(\mathrm{ON}) \\ & +\mathrm{I}_{\mathrm{S}}(\mathrm{ON}) \\ & \hline \end{aligned}$ | $\mathrm{V}_{\mathrm{D}}=10 \mathrm{~V}$ (Note 1) | $\begin{aligned} & \text { MUX-16 } \\ & \text { MUX-28 } \end{aligned}$ | - | $\begin{aligned} & 0.2 \\ & 0.1 \end{aligned}$ | 1 1 | - | $\begin{aligned} & 0.2 \\ & 0.1 \end{aligned}$ | $\begin{aligned} & 2 \\ & 2 \end{aligned}$ | nA |
| Digital Input Current | $\mathrm{I}_{\mathrm{IN}}$ | $\mathrm{V}_{\mathrm{IN}}=0.4 \mathrm{~V}$ to 15 V |  | - | 1 | 10 | - | 1 | 10 | $\mu \mathrm{A}$ |

## MUX16/MUX28

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{S}= \pm 15 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted. Continued

| PARAMETER | SYMBOL | CONDITIONS |  | MUX-16A/E MUX-28A/E |  |  | $\begin{aligned} & \text { MUX-16B/F } \\ & \text { MUX-28B/F } \end{aligned}$ |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Digital "0" Enable Current | $I_{\text {INL }}$ (EN) | $V_{E N}=0.4 \mathrm{~V}$ |  | - | 4 | 10 | - | 4 | 10 | $\mu \mathrm{A}$ |
| Digital Input Capacitance | $C_{\text {DIG }}$ |  |  | - | 3 | - | - | 3 | - | pF |
| Switching Time (than) | ${ }^{t_{\text {PHL }}}$ <br> $t_{\text {PLH }}$ | (Notes 2,5) Figure 1 (Test Circuits) |  | - | $\begin{aligned} & 1.4 \\ & 1.2 \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 1.8 \end{aligned}$ | - | $\begin{aligned} & 1.8 \\ & 1.6 \end{aligned}$ | $\begin{aligned} & 2.5 \\ & 2.2 \end{aligned}$ | $\mu \mathrm{S}$ |
| Output Settling Time | $t_{3}$ | 10V Step to 0.10\% 10V Step to 0.05\% 10V Step to 0.02\% |  | - | $\begin{aligned} & 2.6 \\ & 3.2 \\ & 4.0 \\ & \hline \end{aligned}$ | - | - | $\begin{aligned} & 2.7 \\ & 3.4 \\ & 7.2 \end{aligned}$ | - | $\mu s$ |
| Break-Before-Make Delay | topen | Figure 3 |  | - | 0.7 | - | - | 1 | - | $\mu s$ |
| Enable Delay "ON" | $\mathrm{t}_{\text {ON (EN) }}$ | (Note 5) Figure 2 (Test Circuits) |  | - | 1 | 2 | - | 1.2 | 2.5 | $\mu s$ |
| Enable Delay "OFF" | ${ }^{\text {O OFF (EN) }}$ | (Note 5) Figure 2 (Test Circuits) | $\begin{aligned} & \text { MUX-16 } \\ & \text { MUX-28 } \end{aligned}$ | - | $\begin{aligned} & 0.25 \\ & 0.25 \end{aligned}$ | $\begin{aligned} & 0.5 \\ & 0.5 \end{aligned}$ | - | $\begin{aligned} & 0.25 \\ & 0.25 \end{aligned}$ | $\begin{aligned} & 0.5 \\ & 0.6 \end{aligned}$ | $\mu \mathrm{S}$ |
| "OFF" Isolation | $\mathrm{ISO}_{\text {OFF }}$ | (Note 4) Figure 4 (Test Circuits) |  | - | 66 | - | - | 66 | - | dB |
| Crosstalk | CT | (Note 3) Figure 5 (Test Circuits) |  | - | 75 | - | - | 75 | $\therefore$ - | dB |
| Source Capacitance | $\mathrm{C}_{\text {S (OFF) }}$ | Switch "OFF," $V_{S}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{D}}=0 \mathrm{~V}$ |  | - | 2.5 | - | - | 2.5 | - | pF |
| Drain Capacitance | $C_{\text {d ( OfF) }}$ | Switch "OFF," $V_{S}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{D}}=0 \mathrm{~V}$ | $\begin{aligned} & \text { MUX-16 } \\ & \text { MUX-28 } \end{aligned}$ | - | $\begin{array}{r} 13 \\ 8 \end{array}$ | - | - | $\begin{array}{r}13 \\ 8 \\ \hline\end{array}$ | - | pF |
| Input to Output Capacitance | $\mathrm{C}_{\text {DS (OFF) }}$ | (Note 4) |  | - | 0.15 | - | - | 0.15 | - | pF |
| Positive Supply Current (All Digital Inputs Logic "0" or "1") | $1+$ | $\begin{aligned} & V_{+}=15 \mathrm{~V} \\ & V_{+}=5 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & \text { MUX-16 } \\ & \text { MUX-28 } \\ & \text { MUX-16 } \\ & \text { MUX-28 } \end{aligned}$ | - | 15 <br> 15 <br> 12 <br> 12 | 19 19 | - | 9 <br> 8 <br> 8 <br> 7 | $\begin{array}{r}19 \\ 19 \\ - \\ - \\ \hline\end{array}$ | mA |
| Negative Supply Current (All Digital Inputs Logic "0" or "1") | $1-$ | $\begin{aligned} & V-=-15 V \\ & V-=-5 V \end{aligned}$ | $\begin{aligned} & \text { MUX-16 } \\ & \text { MUX-28 } \\ & \text { MUX-16 } \\ & \text { MUX-28 } \end{aligned}$ | - | 5 5 4 4 | 7 7 - - | - | 3.5 3 3 2.5 | 7 7 - - | mA |

## NOTES:

1. Conditions applied to leakage tests insure worst case leakages.
2. $R_{L}=10 \mathrm{M} \Omega, C_{L}=10 \mathrm{pF}$.
3. Crosstalk is measured by driving channel 8 ( $8 \mathrm{BB}^{*}$ ) with channel 7 ( $7 \mathrm{~B}^{*}$ ) ON . $R_{L}=1 \mathrm{M} \Omega, C_{L}=10 \mathrm{pF}, \mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}$ RMS, $\mathrm{f}=500 \mathrm{kHz}$.
4. "OFF" isolation is measured by driving channel 8 (8B) with ALL channels OFF. $R_{L}=1 \mathrm{k} \Omega, C_{L}=10 \mathrm{pF}, V_{S}=5 \mathrm{~V}$ RMS, $f=500 \mathrm{kHz} . C_{D S}$ is computed from the OFF isolation measurement.
5. Sample tested.
6. Guaranteed by leakage current and $\mathbf{R}_{\mathbf{O N}}$ tests.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{s}= \pm 15 \mathrm{~V},-55^{\circ} \mathrm{C} \leq \mathrm{T}_{A} \leq+125^{\circ} \mathrm{C}$ for MUX-16AT/BT/BTC and MUX-28AT/BT/BTC; $-25^{\circ} \mathrm{C}$ $\leq T_{A} \leq+85^{\circ} \mathrm{C}$ for MUX-16ET and MUX-28ET; $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{A} \leq+85^{\circ} \mathrm{C}$ for MUX-16 FT/FP/FPC and MUX-28FT/FP/FPC, unless otherwise noted.

|  |  |  | MUX-16A/E MUX-28A/E |  |  | MUX-16B/F MUX-28B/F |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | MIN | TYP | MAX | UNITS |
| "ON" Resistance | $\mathrm{R}_{\text {ON }}$ | $V_{s} \leq 10, I_{s} \leq 200 \mu \mathrm{~A}$ | - | - | 500 | - | - | 800 | $\Omega$ |
| $\Delta \mathrm{R}_{\text {ON }}$ With Applied Voltage | $\Delta R_{\text {ON }}$ | $-10 \mathrm{~V} \leq V_{S} \leq 10 \mathrm{~V}, \mathrm{I}_{S}=200 \mu \mathrm{~A}$ | - | 2 | - | - | 5.5 | - | \% |
| $\mathrm{R}_{\text {ON }}$ Match Between Switches | $\mathrm{R}_{\text {ON }}$ Match | $V_{S}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=200 \mu \mathrm{~A}$ | - | 10 | - | - | 15 | - | \% |
| Analog Voltage Range | $V_{\text {A }}$ | (Note 6) | $\begin{array}{r} +10 \\ -10 \\ \hline \end{array}$ | $\begin{array}{r} +11 \\ -15 \\ \hline \end{array}$ | - | $\begin{array}{r} +10 \\ -10 \\ \hline \end{array}$ | $\begin{array}{r} +11 \\ -15 \\ \hline \end{array}$ | - | V |
| Source Current (Switch"OFF") | $l_{S}$ (OFF) | $V_{S}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{D}}=-10 \mathrm{~V}$ (Note 1) | - | - | 25 | - | - | 50 | nA |
| Drain Current (Switch "OFF") | $I_{\text {d (OFF) }}$ | $\mathrm{V}_{\mathrm{S}}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{D}}=-10 \mathrm{~V}$ (Note 1) | - | - | 75 | - | - | 250 | nA |
| Leakage Current (Switch "ON") | $\begin{aligned} & I_{D}(O N) \\ & +I_{S}(O N) \end{aligned}$ | $\mathrm{V}_{\mathrm{D}}=10 \mathrm{~V}$ (Note 1) | - | - | 75 | - | - | 250 | nA |
| Digital "1" Input Voltage | $\mathrm{V}_{\text {INH }}$ | (Note 6) | 2 | - | - | 2 | - | - | V |
| Digital "0" Input Voltage | $\mathrm{V}_{\text {INL }}$ | (Note 6) | - | - | 0.7 | - | - | 0.7 | V |
| Digital Input Current | ${ }_{1 N}$ | $\mathrm{V}_{\text {IN }}=0.4 \mathrm{~V}$ to 15V | - | - | 20 | - | - | 20 | $\mu \mathrm{A}$ |
| Digital "0" Enable Current | $I_{\text {INL }}$ (EN) | $V_{E N}=0.4 \mathrm{~V}$ | - | - | 20 | - | - | 20 | $\mu \mathrm{A}$ |
| Positive Supply Current | $1+$ | All Digital Inputs Logic "0" or "1" | - | - | 24 | - | - | 24 | $m A$ |
| Negative Supply Current | $1-$ | All Digital Inputs Logic "0" or "1" | - | - | 8.2 | - | - | 8.2 | mA |

## FEATURES

- Two Normally Open and Two Normally Closed SPST Switches with Disable
- Switches can be Easily Configured as a Dual SPDT or a DPDT
- Highly Resistant to Static Discharge Destruction
- Higher Resistance to Radiation Than Analog Switches Designed with MOS Devices
- Guaranteed RON Matching 10\% Max
- Guaranteed Switching Speeds ....... TON T 500ns Max

Toff $=400 \mathrm{~ns}$ Max

- Guaranteed Break-Before-Make Switching
- Low "ON" Resistance $\qquad$ $80 \Omega$ Max
- Low Ron Variation from Analog Input Voltage ....... 5\%
- Low Total Harmonic Distortion . . . . . . . . . . . . . . . . . . 0.01\%
- Low Leakage Currents at High Temperature:

$$
\begin{aligned}
& \mathrm{T}_{\mathrm{A}}=125^{\circ} \mathrm{C} \\
& \text { 100nA Max } \\
& T_{A}=85^{\circ} \mathrm{C} \\
& \text { 30nA Max }
\end{aligned}
$$

- Digital Inputs TTL/CMOS Compatible and Independent of V+
- Improved Specifications and Pin Compatible to LF-11333/ 13333
- Dual or Single Power Supply Operation
- Avallable in Die Form

PIN CONNECTIONS


## TRUTH TABLE

|  |  | SWITCH STATE |  |
| :--- | :---: | :---: | :---: |
| DISABLE <br> INPUT | LOGIC | CHANNELS | CHANNELS |
| 0 | INPUT | $1 \& 2$ | $3 \& 4$ |
| 1 or NC | 0 | OFF | OFF |
| 1 or NC | 1 | OFF | ON |

## GENERAL DESCRIPTION

The SW-06 is a four channel single-pole, single-throw analog switch that employs both bipolar and ion-implanted FET devices. The SW-06 FET switches use bipolar digital logic inputs which are more resistant to static electricity than CMOS devices. Ruggedness and reliability are inherent in the SW-06 design and construction technology.
Increased reliability is complemented by excellent electrical specifications. Potential error sources are reduced by minimizing "ON" resistance and controlling leakage currents at high temperatures. The switching FET exhibits minimal $R_{O N}$ variation over a 20 V analog signal range and with power supply voltage changes. Operation from a single positive power supply voltage is possible. With $\mathrm{V}+=36 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V}$, the analog signal range will extend from ground to +32 V .
PNP logic inputs are TTL and CMOS compatible to allow the SW-06 to upgrade existing designs. The logic " 0 " and logic " 1 " input currents are at micro-ampere levels reducing loading on CMOS and TTL logic.

## FUNCTIONAL DIAGRAM



## ORDERING INFORMATION ${ }^{\dagger}$

| PLASTIC | CERDIP | LCC | OPERATING <br> TEMPERATURE <br> 16-PIN |
| :---: | :---: | :---: | :---: |
| - | 16-PIN | 20-CONTACT | RANGE |
| SWO6BQ | SW06BRC/883 | MIL |  |
| SW06GP | SW06FQ | - | XIND |

- For devices processed in total compliance to MIL-STD-883, add /883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.

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Maximum Current Through

| PACKAGE TYPE | $\theta_{\text {1A }}$ (Note 2) | $\theta_{\text {IC }}$ | UNITS |
| :---: | :---: | :---: | :---: |
| 16-Pin Hermetic DIP (Q) | 100 | 16 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 16-Pin Plastic DIP (P) | 82 | 39 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 20-Contact LCC (RC) | 98 | 38 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 16-Pin SOL (S) | 98 | 30 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTES:

1. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
2. $\Theta_{J A}$ is specified for worst case mounting conditions, i.e., $\Theta_{j A}$ is specified for device in socket for CerDIP, P-DIP, and LCC packages; $\boldsymbol{\theta}_{j A}$ is specified for device soldered to printed circuit board for SO package.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}+=15 \mathrm{~V}, \mathrm{~V}-=-15 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | SW-06B |  |  | SW-06F |  |  | SW-06G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| "ON" Resistance | $\mathrm{R}_{\text {ON }}$ | $\mathrm{V}_{\mathrm{S}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=1 \mathrm{~mA}$ | - | 60 | 80 | - | 60 | 100 | - | 100 | 150 |  |
|  |  | $\mathrm{V}_{\mathrm{S}}= \pm 10 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=1 \mathrm{~mA}$ | - | 65 | 80 | - | 65 | 100 | - | 100 | 150 | $\Omega$ |
| $R_{\text {ON }}$ Match Between Switches | RON Match | $V_{S}=0 V_{,} I_{S}=100 \mu \mathrm{~A}$ (Note 1) | - | 5 | 10 | - | 5 | 20 | - | - | 20 | \% |
| Analog Voltage Range | $\mathrm{V}_{\mathrm{A}}$ | $\left.\begin{array}{l} I_{S}=1 \mathrm{~mA} \\ I_{S}=1 \mathrm{~mA} \end{array} \text { (Note } 8\right)$ |  | +11 | - | +10 | +11 | - | +10 | +11 | - | V |
|  |  |  | -10 | -15 | - | -10 | -15 | - | -10 | -15 | - |  |
| Analog Current Range | $I_{A}$ | $\mathrm{V}_{\mathrm{S}}= \pm 10 \mathrm{~V}$ | 10 | 15 | - | 7 | 12 | - | 5 | 10 | - | mA |
| $\Delta R_{\text {ON }}$ vs Applied Voltage | $\Delta R_{\text {ON }}$ | $-10 \mathrm{~V} \leq \mathrm{V}_{S} \leq 10 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=1.0 \mathrm{~mA}$ | $-$ | 5 | 15 | - | 10 | 20 | - | 10 | 20 | \% |
| Source Current in "OFF" Condition | Is(OFF) | $V_{S}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{D}}=-10 \mathrm{~V}$ <br> (Note 5) | - | 0.3 | 2.0 | - | 0.3 | 2.0 | - | 0.3 | 10 | nA |
| Drain Current in "OFF" Condition | ${ }^{\prime} \mathrm{D}$ (OFF) | $V_{S}=10 \mathrm{~V}, V_{D}=-10 \mathrm{~V}$ <br> (Note 5) | - | 0.3 | 2.0 | - | 0.3 | 2.0 | - | 0.3 | 10 | nA |
| Source Current in "ON" Condition | $\mathrm{I}_{\mathrm{S}(\mathrm{ON})+}$ <br> $I_{D(O N)}$ | $\begin{aligned} & V_{S}=V_{D}= \pm 10 \mathrm{~V} \\ & (\text { Note 5) } \end{aligned}$ | - | 0.3 | 2.0 | - | 0.3 | 2.0 | - | 0.3 | 10 | nA |
| Logical "1" Input Voltage | $V_{\text {INH }}$ | Full Temperature Range (Notes 6, 8) | 2.0 | - | - | 2.0 | - | - | 2.0 | - | - | V |
| Logical "0" Input Voltage | $\mathrm{V}_{\text {INL }}$ | Full Temperature Range (Notes 6, 8) | - | - | 0.8 | - | - | 0.8 | - | - | 0.8 | V |
| Logical "1" Input Current | $\mathrm{I}_{\text {INH }}$ | $\mathrm{V}_{\mathrm{IN}}=2.0 \mathrm{~V}$ to 15.0 V <br> (Note 4) | - | - | 5 | - | - | 5 | - | - | 10 | $\mu \mathrm{A}$ |
| Logical "0" Input | $\mathrm{I}_{\text {INL }}$ | $\mathrm{V}_{\text {IN }}=0.8 \mathrm{~V}$ | - | 1.5 | 5.0 | - | 1.5 | 5.0 | - | 1.5 | 10.0 | $\mu \mathrm{A}$ |
| Turn-On-Time | ${ }^{\text {O }} \mathrm{ON}$ | See Switching Time <br> Test Circuit (Notes 6, 9) | - | 340 | 500 | - | 340 | 600 | - | 340 | 700 | ns |
| Turn-Off-Time | ${ }^{\text {toff }}$ | See Switching Time Test Circuit (Notes 6, 9) | - | 200 | 400 | - | 200 | 400 | - | 200 | 500 | ns |
| Break-Before-Make Time | ${ }^{\text {t }} \mathrm{ON}^{-1} \mathrm{OFF}$ | (Note 3) | 50 | 140 | - | 50 | 140 | - | 50 | 140 | - | ns |
| Source Capacitance | $\mathrm{C}_{\text {S (OFF) }}$ | $\mathrm{V}_{\mathrm{S}}=0 \mathrm{~V}$ (Note 5) | - | 7.0 | - | - | 7.0 | - | - | 7.0 | - | pF |
| Drain Capacitance | $C_{\text {d (OFF) }}$ | $\mathrm{V}_{\mathrm{S}}=0 \mathrm{~V}$ (Note 5) | - | 5.5 | - | - | 5.5 | - | - - | 5.5 | - | pF |
| Channel "ON" Capacitance | $\begin{aligned} & \mathrm{C}_{\mathrm{D}(\mathrm{ON})+} \\ & \mathrm{C}_{\mathrm{S}(\mathrm{ON})} \end{aligned}$ | $\mathrm{V}_{\mathrm{S}}=\mathrm{V}_{\mathrm{D}}=0 \mathrm{~V}$ ( Note 5) | - | 15 | - | - | 15 | - | - | 15 | - | pF |
| "OFF" Isolation | ISO(OFF) | $\begin{aligned} & V_{S}=5 V_{\text {RMS }}, R_{L}=680 \Omega, \\ & C_{L}=7 \mathrm{pF}, f=500 \mathrm{kHz} \text { (Note 5) } \end{aligned}$ | - | 58 | - | - | 58 | - | - | 58 | - | dB |
| Crosstalk | $\begin{array}{ll} \mathrm{C}_{\mathrm{T}}=5 \mathrm{~V}_{\mathrm{RMS}}, R_{\mathrm{L}}=680 \Omega, \\ \mathrm{C}_{\mathrm{L}}=7 \mathrm{pF}, \mathrm{f}=500 \mathrm{kHz} \text { (Note 5) } \end{array}$ |  | - | 70 | - | - | 70 | - | - | 70 | dB |  |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{+}=15 \mathrm{~V}, \mathrm{~V}-=-15 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted. Continued

| PARAMETER | SYMBOL | CONDITIONS | MIN | $\begin{gathered} \text { SW-06B } \\ \text { TYP } \end{gathered}$ | MAX | MIN | $\begin{gathered} \text { SW-06F } \\ \text { TYP } \end{gathered}$ | MAX | MIN | $\underset{\text { TYP }}{\substack{\text { SW-06G }}}$ | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Positive Supply Current | I+ | All Channels "OFF", DIS = "0" (Note 5) | - | 5.0 | 6.0 |  | 5.0 | 9.0 | - | 6.0 | 9.0 | mA |
| Negative Supply Current | 1- | All Channels "OFF", DIS = "0" (Note 5) | - | 3.0 | 5.0 | - | 4.0 | 7.0 | - | 4.0 | 7.0 | mA |
| Ground Current | ${ }_{\mathbf{G}}$ | All Channels "ON" or "OFF" (Note 5) | - | 3.0 | 4.0 | - | 3.0 | 4.0 | - | 3.0 | 5.0 | mA |

ELECTRICAL CHARACTERISTICS at $V_{+}=15 \mathrm{~V}, \mathrm{~V}-=-15 \mathrm{~V},-55^{\circ} \mathrm{C} \leq \mathrm{T}_{A} \leq+125^{\circ} \mathrm{C}$ for SW-06BQ, $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ for SW-06FQ and $-40^{\circ} \mathrm{C} \leq T_{A} \leq+85^{\circ} \mathrm{C}$ for SW-06GP/GS, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | SW-06B |  |  | SW-06F |  |  | SW-06G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Temperature Range | $\mathrm{T}_{\text {A }}$ | Operating | -55 | - | 125 | -25 | - | 85 | 0 | - | 70 | ${ }^{\circ} \mathrm{C}$ |
| "ON" Resistance | $\mathrm{R}_{\text {ON }}$ | $\mathrm{V}_{\mathrm{S}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=1.0 \mathrm{~mA}$ | - | 75 | 110 | - | 75 | 125 | - | 75 | 175 | $\Omega$ |
|  |  | $\mathrm{V}_{\mathrm{S}}= \pm 10 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=1.0 \mathrm{~mA}$ | - | 80 | 110 | - | 80 | 125 | - | 80 | 175 |  |
| $R_{\text {ON }}$ Match Between Switches | R ON Match | $\mathrm{V}_{\mathrm{S}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=100 \mu \mathrm{~A}$ (Note 1) | - | 6 | 20 | - | 6 | 25 | - | 10 | - | \% |
| Analog Voltage Range | $\mathrm{V}_{\mathrm{A}}$ | $\mathrm{I}_{\mathrm{S}}=1.0 \mathrm{~mA}$ (Note 8) | +10 | $+11$ | - | +10 | +11 | - | +10 | +11 | - | V |
|  |  | $\mathrm{IS}_{\mathrm{S}}=1.0 \mathrm{~mA}$ | -10 | -15 | - | -10 | -15 | - | -10 | -15 | - |  |
| Analog Current Range | $\mathrm{I}_{\mathrm{A}}$ | $\mathrm{V}_{\mathrm{S}}= \pm 10.0 \mathrm{~V}$ | 7 | 12 | - | 5 | 11 | - | - | 11 | - | mA |
| $\Delta R_{\text {ON }}$ With Applied Voltage | $\Delta \mathrm{R}_{\mathrm{ON}}$ | $\begin{aligned} & -10 \mathrm{~V} \leq \mathrm{V}_{\mathrm{S}} \leq+10 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{S}}=1.0 \mathrm{~mA} \end{aligned}$ | - | 10 | - | - | 12 | - | - | 15 | - | \% |
| Source Current in "OFF" Condition | ${ }^{\text {S S (OFF) }}$ | $\begin{aligned} & V_{S}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{D}}=-10 \mathrm{~V}, \\ & T_{A}=\text { Max. Operating Temp. } \\ & \text { (Notes 5, 7) } \end{aligned}$ | - | - | 60 | - | - | 30 | - | - | 60 | nA |
| Drain Current in "OFF" Condition | ${ }^{\text {d ( OFF })}$ | $\begin{aligned} & V_{S}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{D}}=-10 \mathrm{~V}, \\ & T_{A}=\text { Max. Operating Temp. } \\ & \text { (Notes 5, 7) } \end{aligned}$ | - | - | 60 | - | - | 30 | - | - | 60 | nA |
| Leakage Current in "ON" Condition | $\mathrm{IS}_{\mathrm{S}(\mathrm{ON})^{+}}$ ID(ON) | $V_{S}=V_{D}= \pm 10 \mathrm{~V}$ <br> $T_{A}=$ Max. Operating Temp. <br> (Notes 5, 7) | - | - | 100 | - | - | 30 | - | - | 60 | nA |
| Logical "1" Input Current | IINH | $\begin{aligned} & \mathrm{V}_{\text {IN }}=2.0 \mathrm{~V} \text { to } 15.0 \mathrm{~V} \\ & (\text { Note 4) } \end{aligned}$ | - | - | 10 | - | - | 10 | - | - | 15 | $\mu \mathrm{A}$ |
| Logical "0" Input Current | $I_{\text {INL }}$ | $\mathrm{V}_{\text {IN }}=0.8 \mathrm{~V}$ | - | 4 | 10 | - | 4 | 10 | - | 5 | 15 | $\mu \mathrm{A}$ |
| Turn-On-Time | ${ }^{\text {ton }}$ | See Switching Time <br> Test Circuit (Notes 2, 6) | - | 440 | 900 | - | 500 | 900 | - | - | 1000 | ns |
| Turn-Off-Time | ${ }^{\text {toff }}$ | See Switching Time <br> Test Circuit (Notes 2, 6) | - | 300 | 500 | - | 330 | 500 | - | - | 500 | ns |
| Break-Before-Make Time | $\mathrm{tON}^{-1} \mathrm{OFF}$ | (Note 3) | - | 70 | - | - | 70 | - | - | 50 | - | ns |
| Positive Supply Current | 1+ | All Channels "OFF" DIS = "0" (Note 5) | - | - | 9.0 | - | - | 13.5 | - | - | 13.5 | mA |
| Negative Supply Current | 1- | All Channels "OFF" DIS = "0" (Note 5) | - | - | 7.5 | - | - | 10.5 | - | - | 10.5 | mA |
| Ground Current | $\mathrm{I}_{\mathbf{G}}$ | All Channels "ON" or "OFF" (Note 5) | - | - | 6.0 | - | - | 7.5 | - | - | 7.5 | mA |

## NOTES:

1. $V_{S}=O V, I_{S}=100 \mu \mathrm{~A}$. Specified as a percentage of $R_{\text {AVERAGE }}$ where:
$R_{\text {AVERAGE }}=R_{\text {ON } 1}+R_{\text {ON } 2}+R_{\text {ON } 3}+R_{\text {ON } 4}$
2. Guaranteed by design.
3. Switch is guaranteed by design to provide break-before-make operation.
4. Current tested at $\mathrm{V}_{\mathrm{IN}}=2.0 \mathrm{~V}$. This is worst case condition.
5. Switch being tested ON or OFF as indicated, $\mathrm{V}_{\mathrm{INH}}=2.0 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{INL}}=0.8 \mathrm{~V}$, per logic truth table.
6. Also applies to disable pin.
7. Parameter tested only at $T_{A}=+125^{\circ} \mathrm{C}$ for military grade device.
8. Guaranteed by $\mathrm{R}_{\mathrm{ON}}$ and leakage tests. For normal operation maximum analog signal voltages should be restricted to less than ( $\mathrm{V}+$ ) -4 V .
9. Sample tested.

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## Selection Tree - Voltage References and Regulators



## Voltage References

| Model | Output Voltage V | Initial <br> Accuracy <br> \% FS max | Temp Stability ppm $/{ }^{\circ} \mathrm{C}$ max | Package Options ${ }^{1}$ | Temp Ranges ${ }^{2}$ | Page ${ }^{3}$ | Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| AD589 | +1.235 | 1.2-2.8 | 10-100 | H | C, M/ | 8-22 | Two Terminal, 1.2 V Reference |
| REF191 | +2.048 | 2-10 mV | 5-25 | N, R | I | 8-61 | $45 \mu \mathrm{~A}$ Supply Current, 0.6 V Dropout @ 10 mA Out |
| REF192 | +2.5 | 2-10 mV | 5-25 | N, R | I | 8-61 | $45 \mu$ A Supply Current, 0.6 V Dropout @ 10 mA Out |
| AD780 | +2.5/+3.0 | 0.03-0.04 | 3 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | 8-30 | Ultrahigh Precision +2.5 V/+3.0 V Bandgap Reference |
| AD680 | +2.5 | 0.2-0.4 | 20-30 | N, R, T | C, I | 8-24 | Low Cost, Low Power 2.5 V Reference |
| AD580 | +2.5 | 0.4-3 | 10-85 | H | C, $\mathrm{M}_{\mathbf{D}}$ | 8-5 | Precision, Three Terminal, 2.5 V Reference |
| AD1403/AD1403A | +2.5 | 0.4-1 | 25-40 | N | I | 8-38 | Second Source, 2.5 V Reference |
| REF43 | +2.5 | 0.6-1 | 10-25 | $\mathbf{H}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/ ${ }_{\mathrm{D}}$ | 8-58 | Precision Bandgap Reference |
| REF03 | +2.5 | 0.6 | 50 | N, R | I | CII 6-99 | Low Cost Bandgap Reference |
| REF193 | +3.0 | 10 mV | 25 | N, R | I | 8-61 | $45 \mu$ A Supply Current, 0.6 V Dropout @ 10 mA Out |
| REF 196 | +3.3 | 10 mV | 25 | N, R | I | 8-61 | $45 \mu$ A Supply Current, 0.6 V Dropout @ 10 mA Out |
| REF198 | +4.096 | 2-10 mV | 5-25 | N, $\mathbf{R}$ | I | 8-61 | $45 \mu$ A Supply Current, 0.6 V Dropout @ 10 mA Out |
| REF194 | +4.5 | 2-10 mV | 5-25 | N, R | I | 8-61 | $45 \mu \mathrm{~A}$ Supply Current, 0.6 V Dropout @ 10 mA Out |
| AD586 | +5 | 0.04-0.4 | 5-25 | Q, R | C, $M^{\prime}$ | 8-13 | Precision, Buried Zener 5 V Reference |
| REF195 | +5.0 | 2-10 mV | 5-25 | N, R | I | 8-61 | $45 \mu$ A Supply Current, 0.6 V Dropout @ 10 mA Out |
| REF02 | +5 | 0.3-2.0 | 8.5-250 | $\mathbf{E}, \mathbf{H}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M/w | 8-55 | Precision Bandgap Reference, Adjustable |
| AD2710 | +10 | 0.01 | 1-5 | N | C | CII 6-79 | Ultrahigh Precision 10 V Reference |
| AD2700 | +10 | 0.025-0.05 | 3-10 | D | C, $\mathrm{M} / \mathrm{D}$ | CII 6-75 | Very High Precision 10 V Reference |
| AD587 | +10 | 0.05-0.1 | 5-20 | Q, $\mathbf{R}$ | C, $\mathrm{M}_{\mathbf{D}}$ | 8-16 | Precision 10 V Buried Zener Reference |
| AD581 | +10 | 0.05-0.3 | 5-30 | H | C, $\mathrm{M} /{ }_{\mathrm{D}}$ | 8-7 | Three Terminal 10 V Bandgap Reference |
| REF01 | +10 | 0.3-1.0 | 8.5-65 | $\mathbf{E}, \mathbf{H}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M/ ${ }_{\text {D }}$ | 8-52 | Precision Bandgap Reference |
| AD2712 | $\pm 10$ | 0.01 | 1-5 | N | C | CII 6-79 | Ultrahigh Precision $\pm 10 \mathrm{~V}$ Reference |
| AD688 | $\pm 10$ | 0.02-0.05 | 1.5-6 | Q | I, M/ | 8-27 | High Precision Monolithic $\pm 10 \mathrm{~V}$ Reference |
| AD2702 | $\pm 10$ | 0.025-0.05 | 3-10 | D | C, $\mathrm{M} / \mathrm{D}_{\mathrm{D}}$ | CII 6-75 | Very High Precision $\pm 10 \mathrm{~V}$ Reference |
| AD2701 | -10 | 0.025-0.05 | 3-10 | D | C, $\mathrm{M} / \mathrm{D}$ | CII 6-75 | Very High Precision -10 V Reference |
| AD588 | Selectable | 0.01 | 1.5-6 | E, $\mathbf{N}, \mathbf{Q}$ | C, I, M/ ${ }_{\text {D }}$ | 8-19 | Ultrahigh Precision, Monolithic Programmable Reference |
| AD584 | Selectable | 0.05-0.3 | 5-30 | E, H | C, $\mathrm{M}_{\mathbf{D J}}$ | 8-9 | Precision, Programmable Bandgap Reference |
| REF190 | Adjustable | 10 mV | 5-25 | N, $\mathbf{R}$ | I | 8-61 | $45 \mu \mathrm{~A}$ Supply Current, 0.6 V Dropout @ 10 mA Out |

[^105]
## Selection Guides - Voltage References and Regulators

## Voltage Regulators

| Model | Output Voltage | Output Current | Functions | Package Options ${ }^{1}$ | Temp Ranges ${ }^{2}$ | Page | Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ADM663 | +5 V Fixed, 1.3 to +16 V Adjustable | 40 | Output Boost Temperature Output Shutdown | N, $\mathbf{R}$ | I | 8-40 | MAX663 Replacement |
| ADM666 | +5 V Fixed, 1.3 to +16 V Adjustable | 40 | Low Battery Detect Shutdown | N, R | I | 8-40 | MAX666 Replacement |
| ADM663A | +3.3 V or +5 V Fixed, 1.3 to +16 V Adjustable | 100 | Output Boost Temperature Output Shutdown | N, R, RS | I | 8-46 | Higher Output Replacement |
| ADM666A | +3.3 V or 5 V Fixed, 1.3 to +16 V Adjustable | 100 | Low Battery Detect Shutdown | N, R, RS | I | 8-46 | Higher Output Replacement |




 temperature designator will be followed by: / to indicate 883B, ${ }_{\mathrm{J}}$ for JAN, ${ }_{\mathrm{D}}$ for SMD, and $\mathrm{s}_{\mathrm{s}}$ for space level.
Boldface Type: Data sheet information in this volume.

High Precision 2.5V IC Reference

FEATURES
Laser Trimmed to High Accuracy: 2.500V $\pm 0.4 \%$
3-Terminal Device: Voltage In/Voltage Out
Excellent Temperature Stability: 10ppm/ ${ }^{\circ}$ C (AD580M, U)
Excellent Long Term Stability: $\mathbf{2 5 0 \mu} \mathrm{V}$ ( $25 \mu \mathrm{~V} /$ Month)
Low Quiescent Current: 1.5mA max
Small, Hermetic IC Package: TO-52 Can
MIL-STD-883 Compliant Versions Available

FUNCTIONAL BLOCK DIAGRAM!


## PRODUCT DESCRIPTION

The AD580 is a three-terminal, low cost, temperature compensated, bandgap voltage reference which provides a fixed 2.5 V output for inputs between 4.5 V and 30 V . A unique combination of advanced circuit design and laser-wafer-trimmed thin-film resistors provide the AD580 with an initial tolerance of $\pm 0.4 \%$, a temperature stability of better than $10 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ and long-term stability of better than $250 \mu \mathrm{~V}$. In addition, the low quiescent current drain of 1.5 mA max offers a clear advantage over classical zener techniques.
The AD580 is recommended as a stable reference for all 8 -, 10- and 12-bit D-to-A converters that require an external reference. In addition, the wide input range of the AD580 allows operation with 5 volt logic supplies making the AD580 ideal for digital panel meter applications or whenever only a single logic power supply is available.
The AD580J, K, L and $M$ are specified for operation over the 0 to $+70^{\circ} \mathrm{C}$ temperature range; the AD580S, T and U are specified for operation over the extended temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.

## PRODUCT HIGHLIGHTS

1. Laser-trimming of the thin-film resistors minimizes the AD580 output error. For example, the AD580L output tolerance is $\pm 10 \mathrm{mV}$.
2. The three-terminal voltage in/voltage out operation of the AD580 provides regulated output voltage without any external components.
3. The AD580 provides a stable 2.5 V output voltage for input voltages between 4.5 V and 30 V . The capability to provide a stable output voltage using a 5 -volt input makes the AD580 an ideal choice for systems that contain a single logic power supply.
4. Thin film resistor technology and tightly controlled bipolar processing provide the AD580 with temperature stabilities to $10 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ and long term stability better than $250 \mu \mathrm{~V}$.
5. The low quiescent current drain of the AD580 makes it ideal for CMOS and other low power applications.
6. The AD580 is available in versions compliant with MIL-STD883. Refer to the Analog Devices Military Products Databook or current AD580/883B data sheet for detailed specifications.

## AD580 CHIP DIMENSIONS AND PAD LAYOUT

Dimensions shown in inches and (mm).


The AD580 is also available in chip form. Consult the factory for specifications and applications information.


| Model | Min | AD580J | Max | M |  | Ma |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| OUTPUT VOLTAGE TOLERANCE <br> (Error from Nominal 2.500 Volt Output) |  |  | $\pm 75$ |  |  | $\pm 25$ |  |  | $\pm 10$ |  |  | $\pm 10$ | mV |
| OUTPUT VOLTAGE CHANGE $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ |  |  | $\begin{aligned} & 15 \\ & 85 \\ & \hline \end{aligned}$ |  |  | $\begin{aligned} & 7 \\ & 40 \end{aligned}$ |  |  | $\begin{aligned} & 4.3 \\ & 25 \\ & \hline \end{aligned}$ |  |  | $\begin{aligned} & 1.75 \\ & 10 \\ & \hline \end{aligned}$ | mV <br> ppm $/{ }^{\circ} \mathrm{C}$ |
| LINE REGULATION $\begin{aligned} & 7 \mathrm{~V} \leq \mathrm{V}_{\text {IN }} \leq 30 \mathrm{~V} \\ & 4.5 \mathrm{~V} \leq \mathrm{V}_{\text {IN }} \leq 7 \mathrm{~V} \\ & \hline \end{aligned}$ |  | $\begin{aligned} & 1.5 \\ & 0.3 \end{aligned}$ | $\begin{aligned} & 6 \\ & 3 \end{aligned}$ |  | $\begin{aligned} & 1.5 \\ & 0.3 \end{aligned}$ | $\begin{array}{r} 4 \\ 2 \\ \hline \end{array}$ |  |  | $\begin{aligned} & 2 \\ & 1 \end{aligned}$ |  |  | $\begin{aligned} & 2 \\ & 1 \end{aligned}$ | $\begin{aligned} & \mathrm{mV} \\ & \mathrm{mV} \end{aligned}$ |
| LOADREGULATION $\Delta I=10 \mathrm{~mA}$ |  |  | 10 |  |  | 10 |  |  | 10 |  |  | 10 | mV |
| QUIESCENT CURRENT |  | 1.0 | 1.5 |  | 1.0 | 1.5 |  | 1.0 | 1.5 |  | 1.0 | 1.5 | mA |
| NOISE ( 0.1 Hz to 10 Hz ) |  | 8 |  |  | 8 |  |  | 8 |  |  | 8 |  | $\mu \mathbf{V}(\mathrm{p}-\mathrm{p})$ |
| STABILITY <br> Long Term Per Month |  | $\begin{aligned} & 250 \\ & 25 \end{aligned}$ |  |  | $\begin{aligned} & 250 \\ & 25 \end{aligned}$ |  |  | $\begin{aligned} & 250 \\ & 25 \end{aligned}$ |  |  | $\begin{aligned} & 250 \\ & 25 \\ & \hline \end{aligned}$ |  | $\begin{aligned} & \mu \mathbf{V} \\ & \boldsymbol{\mu} \mathbf{V} \end{aligned}$ |
| TEMPERATURE PERFORMANCE <br> Specified <br> Operating <br> Storage | $\begin{aligned} & 0 \\ & -55 \\ & -65 \\ & \hline \end{aligned}$ |  | $\begin{aligned} & +70 \\ & +125 \\ & +175 \end{aligned}$ | $\begin{aligned} & 0 \\ & -55 \\ & -65 \\ & \hline \end{aligned}$ |  | $\begin{aligned} & +70 \\ & +125 \\ & +175 \end{aligned}$ | $\begin{aligned} & 0 \\ & -55 \\ & -65 \\ & \hline \end{aligned}$ |  | $\begin{aligned} & +70 \\ & +125 \\ & +175 \\ & \hline \end{aligned}$ | $\begin{aligned} & 0 \\ & -55 \\ & -65 \end{aligned}$ |  | $\begin{aligned} & +70 \\ & +125 \\ & +175 \end{aligned}$ | $\begin{aligned} & { }^{\circ} \mathrm{C} \\ & { }^{\circ} \mathrm{C} \\ & { }^{\circ} \mathrm{C} \end{aligned}$ |
| $\begin{aligned} & \hline \text { PACKAGEOPTION * } \\ & \text { TO- } 52(\mathrm{H}-03 \mathrm{~A}) \\ & \hline \end{aligned}$ | AD580JH |  |  | AD580KH |  |  | AD580LH |  |  | AD580MH |  |  |  |



NOTE

* H = Metal Can. For outline information see Package Information section.

Specifications subject to change without notice.
Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.

## FEATURES

Laser-Trimmed to High Accuracy: 10.000 Volts $\pm 5 \mathrm{mV}$ (L and U)

Trimmed Temperature Coefficient:
$5 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ max, 0 to $+70^{\circ} \mathrm{C}$ (L)
$10 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ max, $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ (U)
Excellent Long-Term Stability:
25ppm/1000 hrs. (Noncumulative)
Negative 10 Volt Reference Capability
Low Quiescent Current: 1.0mA max
10mA Current Output Capability
3-Terminal TO-5 Package
MIL-STD-883 Compliant Versions Available

## FUNCTIONAL BLOCK DIAGRAM



BOTTOM VIEW

## PRODUCT DESCRIPTION

The AD581 is a three-terminal, temperature compensated, monolithic band-gap voltage reference which provides a precise 10.00 volt output from an unregulated input level from 12 to 30 volts. Laser Wafer Trimming (LWT) is used to trim both the initial error at $+25^{\circ} \mathrm{C}$ as well as the temperature coefficient, which results in high precision performance previously available only in expensive hybrids or oven-regulated modules. The 5 mV initial error tolerance and $5 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ guaranteed temperature coefficient of the AD581L represent the best performance combination available in a monolithic voltage reference.

The band-gap circuit design used in the AD581 offers several advantages over classical Zener breakdown diode techniques. Most important, no external components are required to achieve full accuracy and stability of significance to low power systems. In addition, total supply current to the device, including the output buffer amplifier (which can supply up to 10 mA ) is typically $750 \mu \mathrm{~A}$. The long-term stability of the band-gap design is equivalent or superior to selected Zener reference diodes.

The AD581 is recommended for use as a reference for 8 -, 10 or 12 -bit D/A converters which require an external precision reference. The device is also ideal for all types of A/D converters up to 14 bit accuracy, either successive approximation or integrating designs, and in general can offer better performance than that provided by standard self-contained references.
The AD581J, K, and L are specified for operation from 0 to $+70^{\circ} \mathrm{C}$; the AD581S, T, and U are specified for the $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ range. All grades are packaged in a hermeticallysealed three-terminal TO-5 metal can.
*Covered by Patent Nos. 3,887,863; RE 30,586

## PRODUCT HIGHLIGHTS

1. Laser trimming of both initial accuracy and temperature coefficient results in very low errors over temperature without the use of external components. The AD581L has a maximum deviation from 10.000 volts of $\pm 7.25 \mathrm{mV}$ from 0 to $+70^{\circ} \mathrm{C}$, while the AD581U guarantees $\pm 15 \mathrm{mV}$ maximum total error without external trims from $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
2. Since the laser trimming is done on the wafer prior to separation into individual chips, the AD581 will be extremely valuable to hybrid designers for its ease of use, lack of required external trims, and inherent high performance.
3. The AD581 can also be operated in a two-terminal "Zener" mode to provide a precision negative 10 volt reference with just one external resistor to the unregulated supply. The performance in this mode is nearly equal to that of the standard three-terminal configuration.
4. Advanced circuit design using the band-gap concept allows the AD581 to give full performance with an unregulated input voltage down to 13 volts. With an external resistor, the device will operate with a supply as low as 11.4 volts.
5. The AD581 is available in versions compliant with MIL-STD883. Refer to the Analog Devices Military Products Databook or current AD581/883B data sheet for detailed specifications.
[^106]
## AD581-SPECIFICATIONS <br> (@ $V_{\mathrm{N}}=+15 \mathrm{~V}$ and $25^{\circ} \mathrm{C}$ )



NOTES
${ }^{1} \mathbf{H}=$ Hermetic Metal Can. For outline information see Package Information section.
Specifications subject to change without notice.
Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All $\min$ and max specifications are guaranteed, although only those shown in boldface are tested on all production units.

## ABSOLUTE MAXIMUM RATINGS

Input Voltage $V_{\text {IN }}$ to Ground . . . . . . . . . . . . . . 40 V
Power Dissipation @ $+25^{\circ} \mathrm{C}$. . . . . . . . . . . 600 mW
Operating Junction Temperature Range . . $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10sec) . . . . . . . $+300^{\circ} \mathrm{C}$
Thermal Resistance
Junction-to-Ambient . . . . . . . . . . . . . ... $150^{\circ} \mathrm{C} / \mathrm{W}$

FEATURES
Four Programmable Output Voltages: 10.000V, 7.500V, 5.000V, 2.500V

Laser-Trimmed to High Accuracies
No External Components Required
Trimmed Temperature Coefficient:
$5 p p m /{ }^{\circ} \mathrm{C}$ max, 0 to $+70^{\circ} \mathrm{C}$ (AD584L)
$15 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ max, $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ (AD584T)
Zero Output Strobe Terminal Provided
Two Terminal Negative Reference
Capability (5V \& Above)
Output Sources or Sinks Current
Low Quiescent Current: 1.0mA max
10 mA Current Output Capability
MIL-STD-883 Compliant Versions Available

PIN CONFIGURATIONS


## PRODUCT DESCRIPTION

The AD584 is an eight-terminal precision voltage reference offering pin-programmable selection of four popular output voltages: $10.000 \mathrm{~V}, 7.500 \mathrm{~V}, 5.000 \mathrm{~V}$ and 2.500 V . Other output voltages, above, below or between the four standard outputs, are available by the addition of external resistors. Input voltage may vary between 4.5 and 30 volts.
Laser Wafer Trimming (LWT) is used to adjust the pin-programmable output levels and temperature coefficients, resulting in the most flexible high precision voltage reference available in monolithic form.

In addition to the programmable output voltages, the AD584 offers a unique strobe terminal which permits the device to be turned on or off. When the AD584 is used as a power supply reference, the supply can be switched off with a single, lowpower signal. In the "off" state the current drain by the AD 584 is reduced to about $100 \mu \mathrm{~A}$. In the "on" state the total supply current is typically $750 \mu \mathrm{~A}$ including the output buffer amplifier.
The AD584 is recommended for use as a reference for 8-, 10or 12 -bit D/A converters which require an external precision reference. The device is also ideal for all types of A/D converters of up to 14 bit accuracy, either successive approximation or integrating designs, and in general can offer better performance than that provided by standard self-contained references.

The AD584J, K and L are specified for operation from 0 to $+70^{\circ} \mathrm{C}$; the AD584S and T are specified for the $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ range. All grades are packaged in a hermetically sealed eight-terminal TO-99 metal can; the AD584J and K are also available in an 8 -pin plastic DIP.
${ }^{*}$ Protected by U.S. Patent No. 3,887,863; RE 30, 586

## PRODUCT HIGHLIGHTS

1. The flexibility of the AD584 eliminates the need to designin and inventory several different voltage references. Furthermore one AD584 can serve as several references simultaneously when buffered properly.
2. Laser trimming of both initial accuracy and temperature coefficient results in very low errors over temperature without the use of external components. The AD584LH has a maximum deviation from 10.000 volts of $\pm 7.25 \mathrm{mV}$ from 0 to $+70^{\circ} \mathrm{C}$.
3. The AD584 can be operated in a two-terminal "Zener" mode at 5 volts output and above. By connecting the input and the output, the AD584 can be used in this "Zener" configuration as a negative reference.
4. The output of the AD584 is configured to sink or source currents. This means that small reverse currents can be tolerated in circuits using the AD584 without damage to the reference and without disturbing the output voltage ( $10 \mathrm{~V}, 7.5 \mathrm{~V}$ and 5 V outputs).
5. The AD584 is available in versions compliant with MIL-STD-883. Refer to the Analog Devices Military Products Databook or current AD584/883B data sheet for detailed specifications.

[^107]

## NOTES

${ }^{1}$ AtPin 1.
${ }^{2}$ Calculated as average over the operating temperature range.
${ }^{3} \mathrm{H}=$ Hermetic Metal Can; $\mathbf{N}=$ Plastic DIP. For package outline information see Package Information section.
Specifications subject to change without notice.
Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All $\min$ and max specifications are guaranteed, although only those shown in boldface are tested on all production units.

## ABSOLUTE MAX RATINGS

Input Voltage VIIN to Ground . . . . . . . . . . . . . . . 40V
Power Dissipation @ $+25^{\circ} \mathrm{C}$. . . . . . . . . . . 600 mW
Operating Junction Temperature Range . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Lead Temperature (Soldering 10sec) . . . . . . . . $+300^{\circ} \mathrm{C}$
Thermal Resistance
Junction-to-Ambient (H-08A) . . . . . . . . . . . $150^{\circ} \mathrm{C} / \mathrm{W}$

METALIZATION PHOTOGRAPH
Dimensions shown in inches and (mm).


INTERCONNECTIONS REQUIRED; SEE PIN DESIGNATIONS FOR INFORMATION.
"*NOT BROUGHT OUT IN PACKAGE DEVICE.
PAD NUMBERS CORRESPOND TO PIN NUMBERS FOR THE TO-99, 8 -PIN METAL PACKAGE.

| Model | AD584S |  |  | AD584T |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max |  |
| OUTPUT VOLTAGE TOLERANCE Maximum Error ${ }^{1}$ for Nominal Outputs of: 10.000 V 7.500 V 5.000 V 2.500 V |  |  | $\begin{aligned} & \pm 30 \\ & \pm 20 \\ & \pm 15 \\ & \pm 7.5 \end{aligned}$ |  |  | $\begin{aligned} & \pm 10 \\ & \pm 8 \\ & \pm 6 \\ & \pm 3.5 \end{aligned}$ | $\begin{aligned} & \mathrm{mV} \\ & \mathrm{mV} \\ & \mathrm{mV} \\ & \mathrm{mV} \end{aligned}$ |
| OUTPUT VOLTAGECHANGE <br> Maximum Deviation from $+25^{\circ} \mathrm{C}$ <br> Value, $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}{ }^{2}$ $10.000,7.500,5.000 \mathrm{~V}$ Outputs 2.500 V Output <br> Differential Temperature Coefficients Between Outputs |  | 5 | $\begin{aligned} & 30 \\ & 30 \end{aligned}$ |  | 3 | $\begin{aligned} & 15 \\ & 20 \end{aligned}$ | $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ <br> $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ <br> $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ |
| QUIESCENTCURRENT Temperature Variation |  | $\begin{aligned} & 0.75 \\ & 1.5 \end{aligned}$ | 1.0 |  | $\begin{aligned} & 0.75 \\ & 1.5 \end{aligned}$ | 1.0 | mA $\mu \mathrm{A} /{ }^{\circ} \mathrm{C}$ |
| TURN-ON SETTLING TIME TO 0.1\% |  | 200 |  |  | 200 |  | $\mu \mathrm{s}$ |
| NOISE $\text { (0.1 to } 10 \mathrm{~Hz} \text { ) }$ |  | 50 |  |  | 50 |  | $\mu \mathrm{V}$ p-p |
| LONG-TERM STABILITY |  | 25 |  |  | 25 |  | ppm/1000 Hrs. |
| SHORT-CIRCUIT CURRENT |  | 30 |  |  | 30 |  | mA |
| $\begin{aligned} & \text { LINE REGULATION (No Load) } \\ & 15 \mathrm{~V} \leq \mathrm{V}_{\mathrm{IN}} \leq 30 \mathrm{~V} \\ & \left(\mathrm{~V}_{\text {OUT }}+2.5 \mathrm{~V}\right) \leq \mathrm{V}_{\text {IN }} \leq 15 \mathrm{~V} \end{aligned}$ |  |  | $\begin{aligned} & 0.002 \\ & 0.005 \end{aligned}$ |  |  | $\begin{aligned} & 0.002 \\ & 0.005 \end{aligned}$ | $\begin{aligned} & \% / \mathrm{V} \\ & \% / \mathrm{V} \end{aligned}$ |
| LOAD REGULATION $0 \leq \mathrm{I}_{\text {Out }} \leq 5 \mathrm{~mA}$, All Outputs |  | 20 | 50 |  | 20 | 50 | ppm/mA |
| OUTPUTCURRENT $\begin{aligned} & \mathrm{V}_{\text {IN }} \geq \mathrm{V}_{\text {OUT }}+2.5 \mathrm{~V} \\ & \text { Source } @+25^{\circ} \mathrm{C} \\ & \text { Source } \mathrm{T}_{\text {min }} \text { to } \mathrm{T}_{\text {max }} \\ & \text { Sink } \mathrm{T}_{\text {min }} \text { to } \mathrm{T}_{\text {max }} \end{aligned}$ | $\begin{aligned} & 10 \\ & 5 \\ & 5 \end{aligned}$ |  |  | $\begin{aligned} & 10 \\ & 5 \\ & 5 \end{aligned}$ |  |  | mA <br> mA <br> mA |
| TEMPERATURE RANGE <br> Operating <br> Storage | $\begin{aligned} & -55 \\ & -65 \end{aligned}$ |  | $\begin{aligned} & +125 \\ & +175 \end{aligned}$ | $\begin{aligned} & -55 \\ & -65 \end{aligned}$ |  | $\begin{aligned} & +125 \\ & +.175 \end{aligned}$ | $\begin{aligned} & { }^{\circ} \mathrm{C} \\ & { }^{\circ} \mathrm{C} \end{aligned}$ |
| PACKAGE OPTION ${ }^{3}$ TO-99(H-08A) | AD584SH |  |  | AD584TH |  |  |  |

## NOTES

${ }^{1}$ At Pin 1.
${ }^{2}$ Calculated as average over the operating temperature range.
${ }^{3} \mathrm{H}=$ Hermetic Metal Can. For package outline information see Package Information section.
Specifications subject to change without notice.

Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All $\min$ and max specifications are guaranteed, although only those shown in boldface are tested on all production units.

## AD584

## APPLYING THE AD584

With power applied to pins 8 and 4 and all other pins open the AD584 will produce a buffered nominal 10.0 V output between pins 1 and 4 (see Figure 1). The stabilized output voltage may be reduced to $7.5 \mathrm{~V}, 5.0 \mathrm{~V}$ or 2.5 V by connecting the programming pins as follows:

## OUTPUT VOLTAGE

7.5 V

## PIN PROGRAMMING

Join the 2.5 V and 5.0 V pins (2) and (3).
5.0V Connect the 5.0 V pin (2) to the output pin (1).
2.5V Connect the 2.5 V pin (3) to the output pin (1).

The options shown above are available without the use of any additional components. Multiple outputs using only one AD584, are also possible by simply buffering each voltage programming pin with a unity-gain noninverting op amp.


Figure 1. Variable Output Options
The AD584 can also be programmed over a wide range of output voltages, including voltages greater than 10 V , by the addition of one or more external resistors. Figure 1 illustrates the general adjustment procedure, with approximate values given for the internal resistors of the AD584. The AD584 may be modeled as an op amp with a noninverting feedback connection, driven by a high stability 1.215 volt bandgap reference (see Figure 3 for schematic).
When the feedback ratio is adjusted with external resistors, the output amplifier can be made to multiply the reference voltage by almost any convenient amount, making popular outputs of $10.24 \mathrm{~V}, 5.12 \mathrm{~V}, 2.56 \mathrm{~V}$ or 6.3 V easy to obtain. The most general adjustment (which gives the greatest range and poorest resolution) uses R1 and R2 alone (see Figure 1). As R1 is adjusted to its upper limit the 2.5 V pin 3 will be connected to the output, which will reduce to 2.5 V . As R1 is adjusted to its lower limit, the output voltage will rise to a value limited by R2. For example, if $R 2$ is about $6 \mathrm{k} \Omega$, the upper limit of the output range will be about 20 V even for large values of R 1 . R 2 should
not be omitted; its value should be chosen to limit the output to a value which can be tolerated by the load circuits. If R2 is zero, adjusting R1 to its lower limit will result in a loss of control over the output voltage. If precision voltages are required to be set at levels other than the standard outputs, the $20 \%$ absolute tolerance in the internal resistor ladder must be accounted for.
Alternatively, the output voltage can be raised by loading the 2.5 V tap with R 3 alone. The output voltage can be lowered by connecting R4 alone. Either of these resistors can be a fixed resistor selected by test or an adjustable resistor. In all cases the resistors should have a low temperature coefficient to match the AD584 internal resistors, which have a negative T.C. less than $60 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$. If both R3 and R4 are used, these resistors should have matched temperature coefficients.
When only small adjustments or trims are required, the circuit of Figure 2 offers better resolution over a limited trim range. The circuit can be programmed to $5.0 \mathrm{~V}, 7.5 \mathrm{~V}$ or 10 V and adjusted by means of $R 1$ over a range of about $\pm 200 \mathrm{mV}$. To trim the 2.5 V output option, R2 (Figure 2) can be reconnected to the bandgap reference (pin 6). In this configuration, the adjustment should be limited to $\pm 100 \mathrm{mV}$ in order to avoid affecting the performance of the AD584.


Figure 2. Output Trimming


Figure 3. Schematic Diagram

FEATURES
Laser Trimmed to High Accuracy: $5.000 \mathrm{~V} \pm 2.0 \mathrm{mV}$ (M Grade)
Trimmed Temperature Coefficient:
2ppm $/{ }^{\circ} \mathrm{C}$ max, 0 to $+70^{\circ} \mathrm{C}$ (M Grade)
5ppm/ ${ }^{\circ} \mathrm{C}$ max, $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ (B Grade)
$10 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ max, $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ (T Grade)
Low Noise, $100 \mathrm{nV} / \sqrt{\mathrm{Hz}}$
Noise Reduction Capability
Output Trim Capability
MIL-STD-883 Compliant Versions Available Industrial Temperature Range SOICs Available Output Capable of Sourcing or Sinking 10 mA

## FUNCTIONAL BLOCK DIAGRAM



NOTE: PINS $1,3 \& 7$ ARE INTERNAL TEST POINTS. MAKE NO CONNECTIONS TO THESE POINTS.

## PRODUCT HIGHLIGHTS

1. Laser trimming of both initial accuracy and temperature coefficients results in very low errors over temperature without the use of external components. The AD586M has a maximum deviation from 5.000 V of $\pm 2.45 \mathrm{mV}$ between 0 and $+70^{\circ} \mathrm{C}$, and the AD586T guarantees $\pm 7.5 \mathrm{mV}$ maximum total error between $-55^{\circ} \mathrm{C}$ and $+125^{\circ} \mathrm{C}$.
2. For applications requiring higher precision, an optional finetrim connection is provided.
3. Any system using an industry standard pinout reference can be upgraded instantly with the AD586.
4. Output noise of the AD586 is very low, typically $4 \mu \mathrm{~V}$ p-p. A noise reduction pin is provided for additional noise filtering using an external capacitor.
5. The AD586 is available in versions compliant with MIL-STD883. Refer to the Analog Devices Military Products Databook or current AD586/883B data sheet for detailed specifications.

This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

## PRODUCT DESCRIPTION

The AD586 represents a major advance in the state-of-the-art in monolithic voltage references. Using a proprietary ion-implanted buried Zener diode and laser wafer trimming of high stability thin-film resistors, the AD586 provides outstanding performance at low cost.
The AD586 offers much higher performance than most other 5 V references. Because the AD586 uses an industry standard pinout, many systems can be upgraded instantly with the AD586. The buried Zener approach to reference design provides lower noise and drift than bandgap voltage references. The AD586 offers a noise reduction pin which can be used to further reduce the noise level generated by the buried Zener.
The AD586 is recommended for use as a reference for 8 -, $10-$, 12-, 14- or 16 -bit D/A converters which require an external precision reference. The device is also ideal for successive approximation or integrating A/D converters with up to 14 bits of accuracy and, in general, can offer better performance than the standard on-chip references.
The AD586J, K, L and M are specified for operation from 0 to $+70^{\circ} \mathrm{C}$, the AD586A and B are specified for $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ operation, and the AD586S and T are specified for $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ operation. The AD586J, K, L and M are available in an 8 -pin plastic DIP. The AD586J, K, L, A and B are available in an 8 -pin plastic surface mount small outline ( SO ) package. The AD586J, K, L, S and T are available in an 8-pin cerdip package.


| Model | AD586J |  |  | AD586K/A |  |  | AD586L/B |  |  | AD586M |  |  | AD586S |  |  | AD586T |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| Output Voltage | 4.980 |  | 5.020 | 4.995 |  | 5.005 | 4.9975 |  | 5.0025 | 4.998 |  | 5.002 | 4.990 |  | 5.010 | 4.9975 |  | 5.0025 | V |
| $\begin{aligned} & \hline \text { Output Voltage Drift }{ }^{1} \\ & 0 \text { to }+70^{\circ} \mathrm{C} \\ & -55^{\circ} \mathrm{C} \text { to }+125^{\circ} \mathrm{C} \\ & \hline \end{aligned}$ |  |  | 25 |  |  | 15 |  |  | 5 |  |  | 2 |  |  | 20 |  |  | 10 | ppm/ $/{ }^{\circ} \mathrm{C}$ |
| Gain Adjustment | $\begin{aligned} & \hline+6 \\ & -2 \\ & \hline \end{aligned}$ |  |  | $\begin{aligned} & +6 \\ & -2 \\ & \hline \end{aligned}$ |  |  | $\begin{aligned} & +6 \\ & -2 \\ & \hline \end{aligned}$ |  |  | $\begin{aligned} & +6 \\ & -2 \end{aligned}$ |  |  | $\begin{array}{r} +6 \\ -2 \\ \hline \end{array}$ |  |  | $\begin{aligned} & +6 \\ & -2 \end{aligned}$ |  |  | \% |
| $\begin{gathered} \text { Line Regulation }{ }^{1} \\ 10.8 \mathrm{~V}<+\mathrm{V}_{\mathrm{IN}}<36 \mathrm{~V} \\ \mathrm{~T}_{\min } \text { to } \mathrm{T}_{\max } \\ 11.4 \mathrm{~V}<+\mathrm{V}_{\mathrm{IN}}<36 \mathrm{~V} \\ \mathrm{~T}_{\min } \text { to } \mathrm{T}_{\max } \\ \hline \end{gathered}$ |  |  | 100 |  |  | 100 |  |  | 100 |  |  | 100 |  |  | 150 |  |  | 150 | $\pm \mu \mathrm{V} / \mathrm{V}$ |
| $\begin{aligned} & \hline \text { Load Regulation }{ }^{1} \\ & \text { Sourcing } 0<\mathrm{I}_{\mathrm{OUT}}<10 \mathrm{~mA} \\ & 25^{\circ} \mathrm{C} \\ & \mathrm{~T}_{\min } \text { to } \mathrm{T}_{\text {max }} \\ & \text { Sinking }-10<\mathrm{I}_{\text {OUT }}<0 \mathrm{~mA} \\ & 25^{\circ} \mathrm{C} \\ & \hline \end{aligned}$ |  |  | $\begin{aligned} & 100 \\ & 100 \\ & 400 \end{aligned}$ |  |  | $\begin{array}{r} 100 \\ 100 \\ 400 \\ \hline \end{array}$ |  |  | $\begin{array}{r} 100 \\ 100 \\ 400 \end{array}$ |  |  | $\begin{aligned} & 100 \\ & 100 \\ & 400 \end{aligned}$ |  |  | $\begin{array}{r} 150 \\ 150 \\ 400 \\ \hline \end{array}$ |  |  | $\begin{aligned} & 150 \\ & 150 \\ & 400 \\ & \hline \end{aligned}$ | $\boldsymbol{\mu V} / \mathrm{mA}$ |
| Quiescent Current |  | 2 | 3 |  | 2 | 3 |  | 2 | 3 |  | 2 | 3 |  | 2 | 3 |  | 2 | 3 | mA |
| Power Consumption |  | 30 |  |  | 30 |  |  | 30 |  |  | 30 |  |  | 30 |  |  | 30 |  | mW |
| Output Noise 0.1 Hz to 10 Hz Spectral Density, 100 Hz |  | $\begin{aligned} & 4 \\ & 100 \\ & \hline \end{aligned}$ |  |  | $\begin{aligned} & 4 \\ & 100 \\ & \hline \end{aligned}$ |  |  | $\begin{aligned} & 4 \\ & 100 \\ & \hline \end{aligned}$ |  |  | $\begin{aligned} & 4 \\ & 100 \\ & \hline \end{aligned}$ |  |  | $\begin{aligned} & 4 \\ & 100 \\ & \hline \end{aligned}$ |  |  | $\begin{aligned} & 4 \\ & 100 \\ & \hline \end{aligned}$ |  | $\begin{aligned} & \mu \mathrm{V} \text { p-p } \\ & \mathrm{nV} / \sqrt{\mathrm{Hz}} \end{aligned}$ |
| Long-Term Stability |  | 15 |  |  | 15 |  |  | 15 |  |  | 15 |  |  | 15 |  |  | 15 |  | ppm $/ 1000 \mathrm{Hr}$ |
| Short-Circuit Current-to-Ground |  | 45 | 60 |  | 45 | 60 |  | 45 | 60 |  | 45 | 60 |  | 45 | 60 |  | 45 | 60 | mA |
| Temperature Range Specified Performance ${ }^{2}$ Operating Performance ${ }^{3}$ | 0 -40 |  | +70 +85 | $\left\lvert\, \begin{aligned} & 0 \\ & -40 \\ & -40 \end{aligned}\right.$ |  | $\begin{aligned} & +70 \\ & +85 \\ & +85 \end{aligned}$ | $\begin{aligned} & 0 \\ & -40 \\ & -40 \end{aligned}$ |  | $\begin{aligned} & +70 \\ & +85 \\ & +85 \end{aligned}$ | 0 -40 |  | +70 +85 | -55 -55 |  | $\begin{aligned} & +125 \\ & +125 \end{aligned}$ | -55 -55 |  | +125 +125 | ${ }^{\circ} \mathrm{C}$ |

NOTES
${ }^{1}$ Maximum output voltage drift is guaranteed for all packages and grades. Cerdip packaged parts are also $100 \%$ production tested
${ }^{2}$ Lower row shows specified performance for $A$ and $B$ grades.
${ }^{3}$ The operating temperature ranged is defined as the temperatures extremes at which the device will still function. Parts may deviate from their specified performance outside their specified temperature range.
Specifications subject to change without notice.
Specifications in boldface are tested on all production units at final electrical test. Result from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units unless otherwise specified.

## ABSOLUTE MAXIMUM RATINGS*

$V_{\text {IN }}$ to Ground . . . . . . . . . . . . . . . . . . . . . . 36V
Power Dissipation ( $25^{\circ} \mathrm{C}$ ) . . . . . . . . . . . . . . . 500 mW
Storage Temperature . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temp (Soldering, 10sec) . . . . . . . . . . . . . $300^{\circ} \mathrm{C}$
Package Thermal Resistance
$\theta_{\mathrm{JC}}$. . . . . . . . . . . . . . . . . . . . . . . . . $22^{\circ} \mathrm{C} / \mathrm{W}$
$\theta_{\mathrm{JA}}$. . . . . . . . . . . . . . . . . . . . . . . . . $110^{\circ} \mathrm{C} / \mathrm{W}$
Output Protection: Output safe for indefinite short to ground or $\mathrm{V}_{\mathrm{IN}}$.
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

CONNECTION DIAGRAM
(Top View)

*TP DENOTES FACTORY TEST POINT. NO CONNECTIONS SHOULD BE MADE TO THESE PINS.

DIE SPECIFICATIONS The following specifiadions are tested at the die e evel tor A05856CHMPS. These die are probed at $25^{5}$ C only. IL SPECIFICATION $\mathbb{T}_{A}=+25^{\circ}, V_{M}=+15$ U uless othemisis specified)

| Parameter | AD586JCHIPS |  |  | Units |
| :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max |  |
| Output Voltage | 4.980 |  | 5.020 | V |
| Gain Adjustment | +6 |  |  | \% |
|  | -2 |  |  | \% |
| Line Regulation $10.8 \mathrm{~V}<+\mathrm{V}_{\mathrm{IN}}<36 \mathrm{~V}$ |  |  | 100 | $\pm \mu \mathrm{V} / \mathrm{V}$ |
| Load Regulation |  |  |  |  |
| Sourcing $0<\mathrm{I}_{\text {OUT }}<10 \mathrm{~mA}$ |  |  | 100 | $\mu \mathrm{V} / \mathrm{mA}$ |
| Sinking $-10<\mathrm{I}_{\text {OUT }}<0 \mathrm{~mA}$ |  |  | 400 | $\mu \mathrm{V} / \mathrm{mA}$ |
| Quiescent Current |  |  | 3 | mA |
| Short-Circuit Current-to-Ground |  |  | 60 | mA |

DIE LAYOUT


NOTES
Die Size: $0.096 \times 0.061$ Inches
${ }^{1}$ Both $V_{\text {OUt }}$ pads should be connected to the output.
Die Thickness: The standard thickness of Analog Devices Bipolar dice is $24 \mathrm{mils} \pm 2 \mathrm{mils}$.
Die Dimensions: The dimensions given have a tolerance of $\pm 2$ mils.
Backing: The standard backside surface is silicon (not plated). Analog Devices does not recommend gold-backed dice for most applications.
Edges: A diamond saw is used to separate wafers into dice thus providing perpendicular edges half-way through the die.
In contrast to scribed dice, this technique provides a more uniform die shape and size. The perpendicular edges facilitate handling (such as tweezer pick-up) while the uniform shape and size simplifies substrate design and die attach.
Top Surface: The standard top surface of the die is covered by a layer of glassivation. All areas are covered except bonding pads and scribe lines.
Surface Metalization: The metalization to Analog Devices bipolar dice is aluminum. Minimum thickness is $10,000 \AA$. Bonding Pads: All bonding pads have a minimum size of 4 mils by 4 mils . The passivation windows have 3.5 mils by 3.5 mils minimum.

ORDERING GUIDE

| Model $^{\mathbf{1}}$ | Initial <br> Error <br> mV | Temp. <br> Coefficient <br> ppm/ $/{ }^{\circ} \mathrm{C}$ | Temp. <br> Range <br> ${ }^{\circ} \mathbf{C}$ | Package <br> Option $^{2}$ |
| :--- | :--- | :---: | :--- | :--- |
| AD586JN | 20 | 25 | 0 to +70 | $\mathrm{~N}-8$ |
| AD586JQ | 20 | 25 | 0 to +70 | $\mathrm{Q}-8$ |
| AD586JR | 20 | 25 | 0 to +70 | $\mathrm{R}-8$ |
| AD586KN | 5 | 15 | 0 to +70 | $\mathrm{~N}-8$ |
| AD586KQ | 5 | 15 | 0 to +70 | $\mathrm{Q}-8$ |
| AD586KR | 5 | 15 | 0 to +70 | $\mathrm{R}-8$ |
| AD586LN | 2.5 | 5 | 0 to +70 | $\mathrm{~N}-8$ |
| AD586LR | 2.5 | 5 | 0 to +70 | $\mathrm{R}-8$ |
| AD586MN | 2 | 2 | 0 to +70 | $\mathrm{~N}-8$ |
| AD586AR | 5 | 15 | -40 to +85 | $\mathrm{~N}-8$ |
| AD586BR | 2.5 | 5 | -40 to +85 | $\mathrm{~N}-8$ |
| AD586LQ | 2.5 | 5 | 0 to +70 | $\mathrm{Q}-8$ |
| AD586SQ | 10 | 20 | -55 to +125 | $\mathrm{Q}-8$ |
| AD586TQ | 2.5 | 10 | -55 to +125 | $\mathrm{Q}-8$ |
| AD586JCHIPS | 20 | 25 | 0 to +70 | - |

## NOTES

${ }^{1}$ For details on grade and package offerings screened in accordance with MIL-STD-883, refer to the Analog Devices Military Products Databook or current AD586/883B data sheet.
${ }^{2} \mathrm{~N}=$ Plastic DIP; Q = Cerdip; R = Small Outline IC(SOIC). For outline information see Package Information section.

## FEATURES

Laser Trimmed to High Accuracy:<br>$10.000 \mathrm{~V} \pm 5 \mathrm{mV}$ (L and U Grades)<br>Trimmed Temperature Coefficient:<br>5ppm/ ${ }^{\circ} \mathrm{C}$ max, (L and U Grades)<br>Noise Reduction Capability<br>Low Quiescent Current: 4mA max<br>Output Trim Capability

MIL-STD-883 Compliant Versions Available

## PRODUCT DESCRIPTION

The AD587 represents a major advance in the state-of-the-art in monolithic voltage references. Using a proprietary ion-implanted buried Zener diode and laser wafer trimming of high stability thin-film resistors, the AD587 provides outstanding performance at low cost.

The AD587 offers much higher performance than most other 10 V references. Because the AD587 uses an industry standard pinout, many systems can be upgraded instantly with the AD587. The buried Zener approach to reference design provides lower noise and drift than band-gap voltage references. The AD587 offers a noise reduction pin which can be used to further reduce the noise level generated by the buried Zener.

The AD587 is recommended for use as a reference for 8 -, $10-$, 12-, 14- or 16 -bit D/A converters which require an external precision reference. The device is also ideal for successive approximation or integrating A/D converters with up to 14 bits of accuracy and, in general, can offer better performance than the standard on-chip references.
The AD587J, K and L are specified for operation from 0 to $+70^{\circ} \mathrm{C}$, and the AD587S, T and U are specified for $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ operation. All grades are available in 8 -pin cerdip. The J and K versions are also available in an 8-pin Small Outline IC (SOIC) package for surface mount applications, while the J, K and L grades also come in an 8-pin plastic package.

## FUNCTIONAL BLOCK DIAGRAM



NOTE: PINS 1, 3 \& 7 ARE INTERNAL TEST POINTS. NO CONNECTIONS TO THESE POINTS.

## PRODUCT HIGHLIGHTS

1. Laser trimming of both initial accuracy and temperature coefficients results in very low errors over temperature without the use of external components. The AD587L has a maximum deviation from 10.000 V of $\pm 8.5 \mathrm{mV}$ between 0 and $+70^{\circ} \mathrm{C}$, and the AD587U guarantees $\pm 14 \mathrm{mV}$ maximum total error between $-55^{\circ} \mathrm{C}$ and $+125^{\circ} \mathrm{C}$.
2. For applications requiring higher precision, an optional finetrim connection is provided.
3. Any system using an industry standard pinout 10 volt reference can be upgraded instantly with the AD587.
4. Output noise of the AD587 is very low, typically $4 \mu \mathrm{~V}$ p-p. A noise reduction pin is provided for additional noise filtering using an external capacitor.
5. The AD587 is available in versions compliant with MIL-STD883. Refer to the Analog Devices Military Products Databook or current AD587/883B data sheet for detailed specifications.

SPEGTFMGATONS $\left(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{IN}}=+15 \mathrm{~V}\right.$ unless otherwise noted)
AD587

| Model | AD587J/S |  |  | AD587K/T |  |  | AD587L/U |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| Output Voltage | 9.990 |  | 10.010 | 9.995 |  | 10.005 | 9.995 |  | 10.005 | V |
| $\begin{aligned} & \text { Output Voltage Drift } \\ & 0 \text { to }+70^{\circ} \mathrm{C} \\ & -55^{\circ} \mathrm{C} \text { to }+125^{\circ} \mathrm{C} \\ & \hline \end{aligned}$ |  |  | $\begin{aligned} & 20 \\ & 20 \end{aligned}$ |  |  | $\begin{aligned} & 10 \\ & 10 \end{aligned}$ |  |  | $\begin{aligned} & 5 \\ & 5 \end{aligned}$ | ppm/ ${ }^{\circ} \mathrm{C}$ |
| Gain Adjustment | $\begin{aligned} & +3 \\ & -1 \\ & \hline \end{aligned}$ |  |  | $\begin{aligned} & +3 \\ & -1 \\ & \hline \end{aligned}$ |  |  | $\begin{array}{r} +3 \\ -1 \\ \hline \end{array}$ |  |  | \% |
| $\begin{aligned} & \text { Line Regulation }^{1} \\ & 13.5 \mathrm{~V} \leqslant+\mathrm{V}_{\text {IN }} \leqslant 36 \mathrm{~V} \\ & \mathrm{~T}_{\min } \text { to } \mathrm{T}_{\max } \end{aligned}$ |  |  | 100 |  |  | 100 |  |  | 100 | $\pm \mu \mathrm{V} / \mathrm{V}$ |
| $\begin{aligned} & \text { Load Regulation }{ }^{1} \\ & \text { Sourcing } 0<I_{\text {OUT }}<10 \mathrm{~mA} \\ & \mathrm{~T}_{\min } \text { to } \mathrm{T}_{\max } \\ & \text { Sinking }-10<\mathrm{I}_{\text {OUT }}<0 \mathrm{~mA}^{2} \\ & \mathrm{~T}_{\min } \text { to } \mathrm{T}_{\max } \end{aligned}$ |  |  | 100 100 |  |  | 100 100 |  |  | $\begin{aligned} & 100 \\ & 100 \\ & \hline \end{aligned}$ | $\pm \mu \mathrm{V} / \mathrm{mA}$ |
| Quiescent Current |  | 2 | 4 |  | 2 | 4 |  | 2 | 4 | mA |
| Power Dissipation |  | 30 |  |  | 30 |  |  | 30 |  | mW |
| Output Noise 0.1 Hz to 10 Hz Spectral Density, 100Hz |  | $\begin{aligned} & 4 \\ & 100 \end{aligned}$ |  |  | $\begin{aligned} & 4 \\ & 100 \end{aligned}$ |  |  | $\begin{aligned} & 4 \\ & 100 \end{aligned}$ |  | $\begin{aligned} & \mu V \mathrm{p}-\mathrm{p} \\ & \mathrm{nV} / \sqrt{\mathrm{Hz}} \end{aligned}$ |
| Long-Term Stability |  | 15 |  |  | 15 |  |  | 15 |  | $\pm \mathrm{ppm} / 1000 \mathrm{Hr}$ |
| Short-Circuit Current-to-Ground |  | 30 | 50 |  | 30 | 50 |  | 30 | 50 | mA |
| Short-Circuit Current-to-V ${ }_{\text {IN }}$ |  | 30 | 50 |  | 30 | 50 |  | 30 | 50 | mA |
| Temperature Range <br> Specified Performance (J, K, L) <br> Operating Performance (J, K, L) ${ }^{3}$ <br> Specified Performance (S, T, U) <br> Operating Performance $(S, T, U)^{3}$ | $\begin{aligned} & 0 \\ & -40 \\ & -55 \\ & -55 \end{aligned}$ |  | $\begin{aligned} & +70 \\ & +85 \\ & +125 \\ & +125 \end{aligned}$ | $\begin{aligned} & 0 \\ & -40 \\ & -55 \\ & -55 \end{aligned}$ |  | $\begin{aligned} & +70 \\ & +85 \\ & +125 \\ & +125 \end{aligned}$ | $\begin{aligned} & 0 \\ & -40 \\ & -55 \\ & -55 \end{aligned}$ |  | $\begin{aligned} & +70 \\ & +85 \\ & +125 \\ & +125 \end{aligned}$ | ${ }^{\circ} \mathrm{C}$ |

NOTES
${ }^{1}$ Spec is guaranteed for all packages and grades. Cerdip packaged parts are $100 \%$ production tested.
${ }^{2}$ Load Regulation (Sinking) specification for SOIC (R) package is $\pm 200 \mu \mathrm{~V} / \mathrm{mA}$.
${ }^{3}$ The operating temperature ranged is defined as the temperatures extremes at which the device will still function.
Parts may deviate from their specified performance outside their specified temperature range.
Specifications subject to change without notice.
ORDERING GUIDE

|  | Initial <br> Error <br> mV | Temp. <br> Coefficient <br> ppm $/{ }^{\circ} \mathbf{C}$ | Temp. <br> Range <br> ${ }^{\circ} \mathbf{C}$ | Package <br> Options $^{2}$ |
| :--- | :---: | :---: | :--- | :--- |
| AD587JQ | 10 | 20 | 0 to +70 | $\mathrm{Q}-8$ |
| AD587JR | 10 | 20 | 0 to +70 | $\mathrm{R}-8$ |
| AD587JN | 10 | 20 | 0 to +70 | $\mathrm{~N}-8$ |
| AD587KQ | 5 | 10 | 0 to +70 | $\mathrm{Q}-8$ |
| AD587KR | 5 | 10 | 0 to +70 | $\mathrm{R}-8$ |
| AD587KN | 5 | 10 | 0 to +70 | $\mathrm{~N}-8$ |
| AD587LQ | 5 | 5 | 0 to +70 | $\mathrm{Q}-8$ |
| AD587LN | 5 | 5 | 0 to +70 | $\mathrm{~N}-8$ |
| AD587SQ | 10 | 20 | -55 to +125 | $\mathrm{Q}-8$ |
| AD587TQ | 10 | 10 | -55 to +125 | $\mathrm{Q}-8$ |
| AD587UQ | 5 | 5 | -55 to +125 | $\mathrm{Q}-8$ |
| AD587JCHIPS | 10 | 20 | 0 to +70 | - |

## NOTES

${ }^{1}$ For details on grade and package offerings screened in accordance with MIL-STD-883, refer to the Analog Devices Military Products Databook or current AD587/883B data sheet.
${ }^{2} \mathrm{~N}=$ Plastic DIP; $\mathrm{Q}=$ Cerdip; $\mathrm{R}=$ SOIC. For outline information see Package Information section.

## AD587

ABSOLUTE MAXIMUM RATINGS*


Output Protection: Output safe for indefinite short to ground and momentary short to $\mathrm{V}_{\mathrm{IN}}$.
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## CONNECTION DIAGRAM


*TP DENOTES FACTORY TEST POINT. NO CONNECTIONS SHOULD BE MADE TO THESE PINS.

DIE SPECIFICATIONS The following specifications are tested at the die level for AD587JCHIPS. These die are probed at $25^{\circ} \mathrm{C}$ only. ( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{IN}}=+15 \mathrm{~V}$ unless otherwise noted)

|  | AD587JCHIPS |  | Parameter |
| :--- | :--- | :--- | :--- |
|  | Min | Typ |  | Units

DIE LAYOUT


[^108]
## FEATURES

Low Drift - 1.5ppm/ ${ }^{\circ} \mathrm{C}$
Low Initial Error - 1mV
Pin-Programmable Output
$+10 \mathrm{~V},+5 \mathrm{~V}, \pm 5 \mathrm{~V}$ Tracking, $-5 \mathrm{~V},-10 \mathrm{~V}$
Flexible Output Force and Sense Terminals
High Impedance Ground Sense
Machine-Insertable DIP Packaging
MIL-STD-883 Compliant Versions Available

## PRODUCT DESCRIPTION

The AD588 represents a major advance in the state-of-the-art in monolithic voltage references. Low initial error and low temperature drift give the AD588 absolute accuracy performance previously not available in monolithic form. The AD588 uses a proprietary ion-implanted buried Zener diode, and laser-wafer-drifttrimming of high stability thin-film resistors to provide outstanding performance at low cost.
The AD588 includes the basic reference cell and three additional amplifiers which provide pin-programmable output ranges. The amplifiers are laser-trimmed for low offset and low drift to maintain the accuracy of the reference. The amplifiers are configured to allow Kelvin connections to the load and/or boosters for driving long lines or high-current loads, delivering the full accuracy of the AD588 where it is required in the application circuit.
The low initial error allows the AD588 to be used as a system reference in precision measurement applications requiring 12-bit absolute accuracy. In such systems, the AD588 can provide a known voltage for system calibration in software and the low drift allows compensation for the drift of other components in a system. Manual system calibration and the cost of periodic recalibration can therefore be eliminated. Furthermore, the mechanical instability of a trimming potentiometer and the potential for improper calibration can be eliminated by using the AD588 in conjunction autocalibration software.
The AD588 is available in seven versions. The AD588 JQ and $K Q$ grades are packaged in a 16 -pin cerdip and are specified for 0 to $+70^{\circ} \mathrm{C}$ operation. AD588AD and BD grades are packaged in a 16 -pin side-brazed ceramic DIP and are specified for the

[^109]
## FUNCTIONAL BLOCK DIAGRAMS


$-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ industrial temperature range. The ceramic AD588SD and TD grades are specified for the full military/aerospace temperature range. For military surface mount applications, the AD588SE and TE grades will also be available in 20-pin LCC packages.

## PRODUCT HIGHLIGHTS

1. The AD588 offers 12-bit absolute accuracy without any user adjustments. Optional fine-trim connections are provided for applications requiring higher precision. The fine-trimming does not alter the operating conditions of the Zener or the buffer amplifiers and thus does not increase the temperature drift.
2. Output noise of the AD588 is very low - typically $6 \mu \mathrm{~V}$ p-p. A pin is provided for additional noise filtering using an external capacitor.
3. A precision $\pm 5 \mathrm{~V}$ tracking mode with Kelvin output connections is available with no external components. Tracking error is less than one millivolt and a fine-trim is available for applications requiring exact symmetry between the +5 V and -5 V outputs.
4. Pin strapping capability allows configuration of a wide variety of outputs: $\pm 5 \mathrm{~V},+5 \mathrm{~V} \&+10 \mathrm{~V},-5 \mathrm{~V} \&-10 \mathrm{~V}$ dual outputs or $+5 \mathrm{~V},-5 \mathrm{~V},+10 \mathrm{~V},-10 \mathrm{~V}$ single outputs.
5. Extensive temperature testing at $-55^{\circ} \mathrm{C},-25^{\circ} \mathrm{C}, 0,+25^{\circ} \mathrm{C}$, $+50^{\circ} \mathrm{C},+70^{\circ} \mathrm{C},+85^{\circ} \mathrm{C}$ and $+125^{\circ} \mathrm{C}$ ensures that the specified temperature coefficient is truly representative of device performance.

|  | AD588SD |  |  | AD588JQ/AD/TD |  |  | AD588KQ/BD |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| $\begin{aligned} & \text { OUTPUT VOLTAGE ERROR } \\ & +10 \mathrm{~V},-10 \mathrm{~V} \text { Outputs } \\ & +5 \mathrm{~V},-5 \mathrm{~V} \text { Outputs } \end{aligned}$ | $\begin{aligned} & -5 \\ & -5 \end{aligned}$ |  | $\begin{aligned} & +5 \\ & +5 \end{aligned}$ | $\begin{aligned} & -3 \\ & -3 \end{aligned}$ |  | $\begin{aligned} & +3 \\ & +3 \end{aligned}$ | $\begin{aligned} & -1 \\ & -1 \end{aligned}$ |  | $\begin{aligned} & +1 \\ & +1 \end{aligned}$ | $\begin{aligned} & \mathrm{mV} \\ & \mathrm{mV} \end{aligned}$ |
| $\begin{aligned} & \pm 5 \text { V TRACKING MODE } \\ & \text { Symmetry Error } \end{aligned}$ | -1.5 |  | +1.5 | -1.5 |  | +1.5 | -0.75 |  | +0.75 | mV |
| $\begin{aligned} & \hline \text { OUTPUT VOLTAGE DRIFT } \\ & 0 \text { to }+70^{\circ} \mathrm{C}(\mathrm{~J}, \mathrm{~K}, \mathrm{~B}) \\ & -25^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C}(\mathrm{~A}, \mathrm{~B}) \\ & -55^{\circ} \mathrm{C} \text { to }+125^{\circ} \mathrm{C}(\mathrm{~S}, \mathrm{~T}) \end{aligned}$ | -6 |  | +6 | $\begin{aligned} & -3 \\ & -3 \\ & -4 \end{aligned}$ | $\pm 2$ | $\begin{aligned} & +3 \\ & +3 \\ & +4 \end{aligned}$ | $\begin{aligned} & -1.5 \\ & -3 \end{aligned}$ |  | $\begin{aligned} & +1.5 \\ & +3 \end{aligned}$ | $\begin{aligned} & \mathrm{ppm} /{ }^{\circ} \mathrm{C} \\ & \mathrm{ppm} /{ }^{\circ} \mathrm{C} \\ & \mathrm{ppm} /{ }^{\circ} \mathrm{C} \end{aligned}$ |
| GAIN ADJ AND BAL ADJ ${ }^{2}$ Trim Range Input Resistance |  | $\begin{aligned} & \pm 4 \\ & 150 \end{aligned}$ |  |  | $\begin{gathered} \pm 4 \\ 150 \end{gathered}$ |  |  | $\begin{array}{r}  \pm 4 \\ 150 \end{array}$ |  | $\begin{aligned} & \mathrm{mV} \\ & \mathrm{k} \Omega \end{aligned}$ |
| LINE REGULATION $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}{ }^{3}$ |  |  | $\pm 200$ |  |  | $\pm 200$ |  |  | $\pm 200$ | $\mu \mathrm{V} / \mathrm{V}$ |
| ```LOAD REGULATION \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) +10 V Output, \(0<\mathrm{I}_{\text {OUT }}<10 \mathrm{~mA}\) -10 V Output, \(-10<\mathrm{I}_{\mathrm{OUT}}<0 \mathrm{~mA}\)``` |  |  | $\begin{aligned} & \pm 50 \\ & \pm 50 \end{aligned}$ |  |  | $\begin{aligned} & \pm 50 \\ & \pm 50 \end{aligned}$ |  |  | $\begin{aligned} & \pm 50 \\ & \pm 50 \end{aligned}$ | $\mu \mathrm{V} / \mathrm{mA}$ <br> $\mu \mathrm{V} / \mathrm{mA}$ |
| SUPPLY CURRENT <br> $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ <br> Power Dissipation |  | $\begin{aligned} & 6 \\ & 180 \end{aligned}$ | $\begin{aligned} & 10 \\ & \mathbf{3 0 0} \end{aligned}$ |  | $\begin{aligned} & 6 \\ & 180 \end{aligned}$ | $\begin{aligned} & 10 \\ & 300 \end{aligned}$ |  | $\begin{aligned} & 6 \\ & 180 \end{aligned}$ | $\begin{aligned} & 10 \\ & 300 \end{aligned}$ | $\begin{aligned} & \mathrm{mA} \\ & \mathrm{~mW} \end{aligned}$ |
| ```OUTPUT NOISE (Any Output) 0.1 to 10Hz Spectral Density, 100Hz``` |  | $\begin{aligned} & 6 \\ & 100 \end{aligned}$ |  |  | $\begin{aligned} & 6 \\ & 100 \end{aligned}$ |  |  | $\begin{aligned} & 6 \\ & 100 \end{aligned}$ |  | $\begin{aligned} & \mu V \mathrm{p}-\mathrm{p} \\ & \mathrm{nV} / \sqrt{\mathrm{Hz}} \end{aligned}$ |
| LONG-TERM STABILITY (@+250 ) |  | 15 |  |  | 15 |  |  | 15 |  | ppm/1000hr |
| BUFFER AMPLIFIERS <br> Offset Voltage <br> Offset Voltage Drift <br> Bias Current <br> Open Loop Gain <br> Output Current A3, A4 <br> Common Mode Rejection (A3, A4) $V_{C M}=1 V p-p$ <br> Short-Circuit Current | $-10$ | $\begin{aligned} & 100 \\ & 1 \\ & 20 \\ & 110 \\ & \\ & 100 \\ & 50 \end{aligned}$ | $+10$ | -10 | $\begin{aligned} & 100 \\ & 1 \\ & 20 \\ & 110 \\ & \\ & 100 \\ & 50 \end{aligned}$ | $+10$ | $-10$ | $\begin{aligned} & 100 \\ & 1 \\ & 20 \\ & 110 \\ & \\ & 100 \\ & 50 \\ & \hline \end{aligned}$ | $+10$ | $\mu \mathrm{V}$ <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ <br> nA <br> dB <br> mA <br> dB <br> mA |
| TEMPERATURE RANGE <br> Specified Performance <br> J, K Grades <br> A, B Grades <br> S, T Grades | -55 |  | +125 | $\begin{aligned} & 0 \\ & -25 \\ & -55 \end{aligned}$ |  | $\begin{aligned} & +70 \\ & +85 \\ & +125 \end{aligned}$ | $\begin{aligned} & 0 \\ & -25 \end{aligned}$ |  | $\begin{aligned} & +70 \\ & +85 \end{aligned}$ | $\begin{aligned} & { }^{\circ} \mathrm{C} \\ & { }^{\circ} \mathrm{C} \\ & { }^{\circ} \mathrm{C} \end{aligned}$ |

NOTES

| 1'Output | Configuration |
| :--- | :--- |
| +10 V | Figure 2a |
| -10 V | Figure 2c |
| $+5 \mathrm{~V},-5 \mathrm{~V}, \pm 5 \mathrm{~V}$ | Figure 2b |

Specifications tested using +10 V configuration unless otherwise indicated.
${ }^{2}$ Gain and balance adjustments guaranteed capable of trimming output voltage
error and symmetry error to zero.
${ }^{3}$ Test Conditions:

$$
\begin{array}{ll}
\text { +10V Output } & -\mathrm{V}_{\mathrm{S}}=-15 \mathrm{~V}, 13.5 \mathrm{~V} \leq+\mathrm{V}_{\mathrm{S}} \leq 18 \mathrm{~V} \\
\text {-10V Output } & -18 \mathrm{~V} \leq-\mathrm{V}_{\mathrm{S}} \leq-13.5 \mathrm{~V},+\mathrm{V}_{\mathrm{S}}=15 \mathrm{~V} \\
\pm 5 \mathrm{~V} \text { Output } & +\mathrm{V}_{\mathrm{S}}=+18 \mathrm{~V},-\mathrm{V}_{\mathrm{S}}=-18 \mathrm{~V} \\
& +\mathrm{V}_{\mathrm{S}}=+10.8 \mathrm{~V},-\mathrm{V}_{\mathrm{S}}=-10.8 \mathrm{~V}
\end{array}
$$

Specifications subject to change without notice.
Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.

ORDERING GUIDE

| Part <br> Number | Initial <br> Error | Temperature <br> Coefficient | Temperature <br> Range ${ }^{\circ} \mathrm{C}$ | Package <br> Option |
| :--- | :--- | :--- | :--- | :--- |
| AD588AD | 3 mV | $3 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ | -25 to +85 | Ceramic (D-16) |
| AD588BD | 1 mV | $1.5 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ | -25 to $+85^{3}$ | Ceramic(D-16) |
| AD588SD | 5 mV | $6 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ | -55 to +125 | Ceramic(D-16) |
| AD588TD | 3 mV | $4 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ | -55 to +125 | Ceramic (D-16) |
| AD588JQ | 3 mV | $3 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ | 0 to +70 | Cerdip(Q-16) |
| AD588KQ | 1 mV | $1.5 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ | 0 to +70 | Cerdip(Q-16) |

NOTES
${ }^{1}$ For details on grade and package offerings screened in accordance with MIL-STD-883, refer to the Analog Devices Military Products Databook or current AD588/883B data sheet.
${ }^{2}$ For outline information see Package Information section.
${ }^{3}$ Temperature coefficient specified from 0 to $+70^{\circ} \mathrm{C}$.

## ABSOLUTE MAXIMUM RATINGS*

$+V_{S}$ to $-V_{S}$. . . . . . . . . . . . . . . . . . . . . . 36V
Power Dissipation ( $+25^{\circ} \mathrm{C}$ )
D Package . . . . . . . . . . . . . . . . . . . . . 600mW
Storage Temperature . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10sec) . . . . . . . . . . $300^{\circ} \mathrm{C}$

## Package Thermal Resistance

$$
\mathrm{D}\left(\theta_{\mathrm{JA}} / \theta_{\mathrm{JC}}\right)
$$

$90 / 25^{\circ} \mathrm{C} / \mathrm{W}$
Output Protection: All outputs safe if shorted to ground
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## APPLYING THE AD588

The AD588 can be configured to provide +10 V and -10 V reference outputs as shown in Figures 2a and 2c respectively. It can also be used to provide $+5 \mathrm{~V},-5 \mathrm{~V}$ or a $\pm 5 \mathrm{~V}$ tracking reference as shown in Figure 2b. Table I details the appropriate pin connections for each output range. In each case, pin 9 is connected to system ground and power is applied to pins 2 and 16.

The architecture of the AD588 provides ground sense and uncommitted output buffer amplifiers which offer the user a great deal of functional flexibility. The AD588 is specified and tested in the configurations shown in Figure 2. The user may choose to take advantage of the many other configuration options available with the AD588. However, performance in these configurations is not guaranteed to meet the extremely stringent data sheet specifications.
As indicated in Table I, a +5 V buffered output can be provided using amplifier A4 in the +10 V configuration (Figure 2a). A -5 V buffered output can be provided using amplifier A3 in the -10 V configuration (Figure 2c). Specifications are not guaranteed for the +5 V or -5 V outputs in these configurations. Performance will be similar to that specified for the +10 V or -10 V outputs.
As indicated in Table I, unbuffered outputs are available at pins 6,8 and 11. Loading of these unbuffered outputs will impair circuit performance.
Amplifiers A3 and A4 can be used interchangeably. However, the AD588 is tested (and the specifications are guaranteed) with the amplifiers connected as indicated in Figure 2 and Table I.

## PIN CONFIGURATIONS



NC $=$ NO CONNECT
When either A3 or A4 is unused, its output force and sense pins should be connected and the input tied to ground.
Two outputs of the same voltage may be obtained by connecting both A3 and A4 to the appropriate unbuffered output on pin 6, 8 or 11. Performance in these dual output configurations will typically meet data sheet specifications.

| Range | Connect <br> Pin 10 <br> to Pin: | Unbuffered ${ }^{1}$ Output on Pins |  |  |  |  | Buffered <br> Output <br> Connections | Buffered Output on Pins |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | -10V | 5V | 0V | +5V | $+10 \mathrm{~V}$ |  | -10V | -5V | 0V | +5V | +10V |
| +10V | 8 | - | - | 8 | 11 | 6 | 11-13 \& 14-15 | - | - | - | 15 | - |
|  |  |  |  |  |  |  | 6-4 \& 3-1 | - | - | - | - | 1 |
| -5 V or +5 V | 11 | - | 8 | 11 | 6 | - | 8-13 \& 14-15 | - | 15 | - | - | - |
|  |  |  |  |  |  |  | 6-4 \& 3-1 | - | - | - | 1 | - |
| -10V | 6 | 8 | 11 | 6 | - | - | 8-13 \& 14-15 | 15 | - | - | - | - |
|  |  |  |  |  |  |  | .11-4 \& 3-1 | - | 1 | - | - | - |
| $+5 \mathrm{~V}$ |  | - | - | - | 6 | - | 6-4 \& 3-1 | - | - | - | 1 | - |
|  | 11 |  |  |  |  |  |  |  |  |  |  |  |
| -5V |  | - | 8 | - | - | - | 8-13 \& 14-15 | - | 15 | - | - | - |

[^110]ANALOG

## FEATURES

Superior Replacement for Other 1.2V References<br>Wide Operating Range: $50 \mu \mathrm{~A}$ to 5 mA<br>Low Power: $\mathbf{6 0 \mu W}$ Total $P_{D}$ at $50 \mu \mathrm{~A}$<br>Low Temperature Coefficient:<br>$10 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ max, 0 to $+70^{\circ} \mathrm{C}$ (AD589M)<br>25ppm $/{ }^{\circ} \mathrm{C}$ max, $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ (AD589U)<br>Two-Terminal "Zener" Operation<br>Low Output Impedance: $0.6 \Omega$<br>No Frequency Compensation Required<br>Low Cost<br>MIL-STD-883 Compliant Versions Available

## PRODUCT DESCRIPTION

The AD589 is a two-terminal, low cost, temperature compensated bandgap voltage reference which provides a fixed 1.23 V output voltage for input currents between $50 \mu \mathrm{~A}$ and 5.0 mA .

The high stability of the AD589 is primarily dependent upon the matching and thermal tracking of the on-chip components. Analog Devices' precision bipolar processing and thin-film technology combine to provide excellent performance at low cost.

Additionally, the active circuit produces an output impedance ten times lower than typical low-TC zener diodes. This feature allows operation with no external components required to maintain full accuracy under changing load conditions.

The AD589 is available in seven versions. The AD589J, K, L and M grades are specified for 0 to $+70^{\circ} \mathrm{C}$ operation, while the $\mathrm{S}, \mathrm{T}$ and U grades are rated for the full $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ temperature range. All grades are available in a metal can ( $\mathrm{H}-02 \mathrm{~A}$ ) package. The AD589J is also available in an 8-pin SOIC package.


## PRODUCT HIGHLIGHTS

1. The AD589 is a two-terminal device which delivers a a constant reference voltage for a wide range of input current.
2. Output impedance of $0.6 \Omega$ and temperature coefficients as low as $10 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ insure stable output voltage over a wide range of operating conditions.
3. The AD589 can be operated as a positive or negative reference. "Floating" operation is also possible.
4. The AD589 will operate with total current as low as $50 \mu \mathrm{~A}$ ( $60 \mu \mathrm{~W}$ total power dissipation), ideal for battery powered instrument applications.
5. The AD589 is an exact replacement for other 1.2 V references, offering superior temperature performance and reduced sensitivity to capacitive loading.
6. The AD589 is available in versions compliant with MIL-STD-883. Refer to the Analog Devices Military Products Databook or current AD589/883B data sheet for detailed specifications.

| Model |  | AD589JH | /JR |  | D589K |  |  | D589L |  |  | AD589 |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | Units |
| OUTPUT VOLTAGE, $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | 1.200 | 1.235 | 1.250 | 1.200 | 1.235 | 1.250 | 1.200 | 1.235 | 1.250 | 1.200 | 1.235 | 1.250 | V |
| ```OUTPUT VOLTAGE CHANGE vs. CURRENT \((50 \mu \mathrm{~A}-5 \mathrm{~mA})\)``` | 5 |  |  | 5 |  |  | 5 |  |  | 5 |  |  | mV |
| DYNAMIC OUTPUT IMPEDANCE |  | 0.6 | 2 |  | 0.6 | 2 |  | 0.6 | 2 |  | 0.6 | 2 | $\Omega$ |
| RMS NOISE VOLTAGE $10 \mathrm{~Hz}<\mathrm{f}<10 \mathrm{kHz}$ | 5 |  |  | 5 |  |  | 5 |  |  | 5 |  |  | $\mu \mathrm{V}$ |
| TEMPERATURE COEFFICIENT ${ }^{1}$ |  |  | 100 |  |  | 50 |  |  | 25 |  |  | 10 | ppm/ ${ }^{\circ} \mathrm{C}$ |
| TURN-ON SETTLING TIME TO 0.1\% | 25 |  |  | 25 |  |  | 25 |  |  | 25 |  |  | $\mu \mathrm{s}$ |
| OPERATING CURRENT ${ }^{2}$ | 0.05 |  | 5 | 0.05 |  | 5 | 0.05 |  | 5 | 0.05 |  | 5 | mA |
| OPERATING TEMPERATURE | 0 |  | $+70$ | 0 |  | $+70$ | 0 |  | $+70$ | 0 |  | +70 | ${ }^{\circ} \mathrm{C}$ |
| PACKAGEOPTION ${ }^{3}$ <br> Metal Can (H-02A) SOIC(R-8) | $\begin{aligned} & \text { AD589JH } \\ & \text { AD589JR } \end{aligned}$ |  |  | AD589KH |  |  | AD589LH |  |  | AD589MH |  |  |  |


| Model | AD589SH |  |  | AD589TH |  |  | AD589UH |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| OUTPUTVOLTAGE, $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | 1.200 | 1.235 | 1.250 | 1.200 | 1.235 | 1.250 | 1.200 | 1.235 | 1.250 | V |
| ```OUTPUT VOLTAGE CHANGE vs. CURRENT \((50 \mu \mathrm{~A}-5 \mathrm{~mA})\)``` |  |  | 5 |  |  | 5 |  |  | 5 | mV |
| DYNAMIC OUTPUT IMPEDANCE |  | 0.6 | 2 |  | 0.6 | 2 |  | 0.6 | 2 | $\Omega$ |
| RMS NOISE VOLTAGE $10 \mathrm{~Hz}<\mathrm{f}<10 \mathrm{kHz}$ |  | 5 |  |  | 5 |  |  | 5 |  | $\mu \mathrm{V}$ |
| TEMPERATURE COEFFICIENT ${ }^{1}$ |  |  | 100 |  |  | 50 |  |  | 25 | ppm $/{ }^{\circ} \mathrm{C}$ |
| TURN-ON SETTLING TIME TO 0.1\% |  | 25 |  |  | 25 |  |  | 25 |  | $\mu s$ |
| OPERATING CURRENT ${ }^{2}$ | 0.05 |  | 5 | 0.05 |  | 5 | 0.05 |  | 5 | mA |
| OPERATING TEMPERATURE | -55 |  | +125 | -55 |  | + 125 | -55 |  | + 125 | ${ }^{\circ} \mathrm{C}$ |
| $\begin{gathered} \text { PACKAGE OPTION }{ }^{3} \\ \text { Metal Can }(\mathrm{H}-02 \mathrm{~A}) \end{gathered}$ | AD589SH |  |  | AD589TH |  |  | AD589UH |  |  |  |

## NOTES

${ }^{1}$ See following page for explanation of temperature coefficient measurement method.
${ }^{2}$ Optimum performance is obtained at currents below $500 \mu \mathrm{~A}$. For current operation below $200 \mu \mathrm{~A}$, stray shunt capacitances should be limited to 20 pF or increased to $l \mu \mathrm{~F}$. If strays can not be avoided, operation at $500 \mu \mathrm{~A}$ and a shunt capacitor of at least 1000 pF are recommended.
${ }^{\mathbf{3}} \mathrm{H}=$ Hermetic Metal Can; $\mathrm{R}=$ SOIC. For outline information see Package Information section.
Specifications shown in boldface are tested on all production units at final electrical test. Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS

Current
10 mA
Reverse Current . . . . . . . . . . . . . . . . . . . . 10 mA
Power Dissipation ${ }^{1}$. . . . . . . . . . . . . . . . . 125mW
Storage Temperature Range . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+175^{\circ} \mathrm{C}$
Operating Junction Temperature Range . $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10sec) . . . . . . . . $+300^{\circ} \mathrm{C}$

## NOTE

${ }^{1}$ Absolute maximum power dissipation is limited by maximum current through the device. Maximum rating at elevated temperatures must be computed assuming $\mathrm{T}_{\mathrm{J}} \leqslant 150^{\circ} \mathrm{C}$, and $\theta_{\mathrm{JA}}=400=\mathrm{C} / \mathrm{W}$.

## AD589 CHIP DIMENSIONS AND PAD LAYOUT



THE AD589 IS AVAILABLE IN CHIP FORM WITH
FULLY TESTED AND GUARANTEED SPECIFI. CATIONS. CONSULT FACTORY FOR AVAILABLE GRADES AND PRICING.

## FEATURES

Low Quiescent Current: $\mathbf{2 5 0} \boldsymbol{\mu} \mathbf{A}$ max Laser Trimmed to High Accuracy: $2.5 \mathrm{~V} \pm 5 \mathrm{mV} \max$ (AN, AR Grade)
Trimmed Temperature Coefficient: $20 \mathrm{ppm} /{ }^{\circ} \mathrm{C} \max$ (AN, AR Grade)
Low Noise: $\mathbf{8 \mu V} p-p$ from 0.1 to 10 Hz $250 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ Wideband Temperature Output Pin (N, R Packages) Available in Three Package Styles: 8-Pin Plastic DIP, 8-Pin SOIC and 3-Pin TO-92

## PRODUCT DESCRIPTION

The AD680 is a bandgap voltage reference which provides a fixed 2.5 V output from inputs between 4.5 V and 36 V . The architecture of the AD680 enables the reference to be operated at a very low quiescent current while still realizing excellent dc characteristics and noise performance. Trimming of the high stability thin-film resistors is performed for initial accuracy and temperature coefficient, resulting in low errors over temperature.
The precision dc characteristics of the AD680 make it ideal for use as a reference for D/A converters which require an external precision reference. The device is also ideal for A/D converters and, in general, can offer better performance than the standard on-chip references.
Based upon the low quiescent current of the AD680, which rivals that of many incomplete two-terminal references, the AD680 is recommended for low power applications such as hand-held battery equipment.
A temperature output pin is provided on the 8-pin package versions of the AD680. The temperature output pin provides an output voltage that varies linearly with temperature and allows the AD680 to be configured as a temperature transducer while providing a stable 2.5 V output.
The AD680 is available in five grades. The AD680AN is specified for operation from $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$, while the AD680JN is specified for $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ operation. Both the AD680AN and AD680JN are available in 8-pin plastic DIP packages. The AD680AR is specified for operation from $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$, while the AD680JR is specified for $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ operation. Both are available in an 8-pin Small Outline IC (SOIC) package. The AD680JT is specified for $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ operation and is available in a 3 -pin TO-92 package.
*Protected by U.S. Patent Nos. 4,902,959; 4,250,445 and 4,857,862.

## CONNECTION DIAGRAMS


*TP DENOTES FACTORY TEST POINT.
NO CONNECTIONS SHOULD BE MADE TO THESE PINS.

## PRODUCT HIGHLIGHTS

1. The AD680 bandgap reference operates on a very low quiescent current which rivals that of many two-terminal references. This makes the complete, higher accuracy AD680 ideal for use in power sensitive applications.
2. Laser trimming of both initial accuracy and temperature coefficients results in low errors over temperature without the use of external components. The AD680AN and AD680AR have a maximum variation of 6.25 mV between $-40^{\circ} \mathrm{C}$ and $+85^{\circ} \mathrm{C}$.
3. The AD680 noise is low, typically $8 \mu \mathrm{~V}$ p-p from 0.1 to 10 Hz . Spectral density is also low, typically $250 \mathrm{nV} / \sqrt{\mathrm{Hz}}$.
4. The temperature output pin on the 8 -pin package versions enables the AD680 to be configured as a temperature transducer.
5. Plastic DIP packaging provides machine insertability, while SOIC packaging provides surface mount capability. TO-92 packaging offers a cost effective alternative to two-terminal references, offering a complete solution in the same package in which two-terminal references are usually found.

SPECIFICATIONS $\left(\tau_{A}=+25^{\circ} \mathrm{C}, v_{1 \mathbb{L}}=+5 \mathrm{~V}\right.$ unless otherwise specified $)$
AD680

| Model | AD680AN/AR |  |  | AD680JN/JR |  |  | AD680JT |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| OUTPUT VOLTAGE | 2.495 |  | 2.505 | 2.490 |  | 2.510 | 2.490 |  | 2.510 | V |
| $\begin{aligned} & \hline \text { OUTPUT VOLTAGE DRIFT }^{1} \\ & 0^{\circ} \mathrm{C} \text { to }+70^{\circ} \mathrm{C} \\ & -40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \\ & \hline \end{aligned}$ |  | 10 | 20 |  | $\begin{aligned} & 10 \\ & 25 \end{aligned}$ | 25 |  |  | 30 | ppm $/{ }^{\circ} \mathrm{C}$ |
| LINE REGULATION $\begin{gathered} 4.5 \mathrm{~V} \leq+\mathrm{V}_{\mathrm{IN}} \leq 15 \mathrm{~V} \\ \left(@ \mathrm{~T}_{\min } \text { to } \mathrm{T}_{\max }\right) \\ 15 \mathrm{~V} \leq+\mathrm{V}_{\text {IN }} \leq 36 \mathrm{~V} \\ \left(@ \mathrm{~T}_{\min } \text { to } \mathrm{T}_{\max }\right) \end{gathered}$ |  |  | $\begin{aligned} & 40 \\ & 40 \\ & 40 \\ & 40 \end{aligned}$ |  |  |  |  |  |  | $\mu \mathrm{V} / \mathrm{V}$ |
| $\begin{aligned} & \hline \text { LOAD REGULATION } \\ & 0<\mathrm{I}_{\text {OUT }}<10 \mathrm{~mA} \\ & \left(@ \mathrm{~T}_{\min } \text { to } \mathrm{T}_{\max }\right. \text { ) } \end{aligned}$ |  | $\begin{aligned} & 80 \\ & 80 \end{aligned}$ | $\begin{aligned} & 100 \\ & 100 \end{aligned}$ |  |  | * |  |  |  | $\mu \mathrm{V} / \mathrm{mA}$ |
| QUIESCENT CURRENT (@ $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ ) |  | 195 | $\begin{aligned} & 250 \\ & 280 \end{aligned}$ |  | * |  |  | * |  | $\mu \mathrm{A}$ |
| POWER DISSIPATION |  | 1 | 1.25 |  | * | * |  | * | * | mW |
| OUTPUT NOISE <br> 0.1 to 10 Hz <br> Spectral Density, 100 Hz |  | $\begin{aligned} & 8 \\ & 250 \end{aligned}$ | 10 |  |  | * |  |  | * | $\begin{aligned} & \mu V \mathrm{p}-\mathrm{p} \\ & \mathrm{nV} / \sqrt{\mathrm{Hz}} \end{aligned}$ |
| CAPACITIVE LOAD |  |  | 50 |  |  | * |  |  | * | nF |
| LONG TERM STABILITY |  | 25 |  |  | * |  |  | * |  | ppm/1000 hr |
| SHORT CIRCUIT CURRENT TO GROUND |  | 25 | 50 |  | * | * |  | * | * | mA |
| TEMPERATURE PIN <br> Voltage Output © $25^{\circ} \mathrm{C}$ Temperature Sensitivity Output Current Output Resistance | $\begin{aligned} & 540 \\ & -5 \end{aligned}$ | $\begin{aligned} & 596 \\ & 2 \\ & 12 \end{aligned}$ | $\begin{array}{r} 660 \\ +5 \end{array}$ |  |  |  |  |  |  | $\begin{aligned} & \mathrm{mV} \\ & \mathrm{mV} /{ }^{\circ} \mathrm{C} \\ & \mu \mathrm{~A} \\ & \mathrm{k} \Omega \end{aligned}$ |
| TEMPERATURE RANGE Specified Performance Operating Performance ${ }^{2}$ | $\begin{aligned} & -40 \\ & -40 \end{aligned}$ |  | $\begin{aligned} & +85 \\ & +85 \end{aligned}$ | $\begin{aligned} & 0 \\ & -40 \end{aligned}$ |  | $\begin{aligned} & +70 \\ & +85 \end{aligned}$ | $\begin{aligned} & 0 \\ & -40 \end{aligned}$ |  | $\begin{aligned} & +70 \\ & +85 \end{aligned}$ | ${ }^{\circ} \mathrm{C}$ |

## NOTES

${ }^{1}$ Maximum output voltage drift is guaranteed for all packages.
${ }^{2}$ The operating temperature range is defined as the temperature extremes at which the device will still function. Parts may deviate from their specified performance outside their specified temperature range.
*Same as AD680AN/AR specification.
Specifications subject to change without notice.
Specifications in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed.

## ABSOLUTE MAXIMUM RATINGS*

$\mathrm{V}_{\text {IN }}$ to Ground . . . . . . . . . . . . . . . . . . . . . . . . . . . 36 V
Power Dissipation $\left(25^{\circ} \mathrm{C}\right)$. . . . . . . . . . . . . . . . . . . 500 mW
Storage Temperature . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 sec) . . . . . . . . . . . . . $300^{\circ} \mathrm{C}$
Package Thermal Resistance
$\theta_{\mathrm{JA}}$ (All Packages) . . . . . . . . . . . . . . . . . . . . . . $120^{\circ} \mathrm{C} / \mathrm{W}$
Output Protection: Output safe for indefinite short to ground and momentary short to $\mathrm{V}_{\text {IN }}$.
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## 8-Pin Plastic DIP and 8-Pin SOIC Packages


*TP DENOTES FACTORY TEST POINT. NO CONNECTIONS SHOULD BE MADE TO THESE PINS.


Figure 1. Connection Diagrams

## THEORY OF OPERATION

Bandgap references are the high performance solution for low supply voltage operation. A typical precision bandgap will consist of a reference core and buffer amplifier. Based on a new, patented bandgap reference design (Figure 2), the AD680 merges the amplifier and the core bandgap function to produce a compact, complete precision reference. Central to the device is a high gain amplifier with an intentionally large Proportional To Absolute Temperature (PTAT) input offset. This offset is controlled by the area ratio of the amplifier input pair, Q1 and Q2, and is developed across resistor R1. Transistor Q12's base emitter voltage has a Complementary To Absolute Temperature (CTAT) characteristic. Resistor R2 and the parallel combination of R3 and R4 "multiply" the PTAT voltage across R1. Trimming resistors R3 and R4 to the proper ratio produces a temperature invariant 2.5 V at the output. The result is an accurate, stable output voltage accomplished with a minimum number of components.


Figure 2. AD680 Schematic Diagram
An additional feature with this approach is the ability to minimize the noise while maintaining very low overall power dissipation for the entire circuit. Frequently it is difficult to independently control the dominant noise sources for bandgap references: bandgap transistor noise and resistor thermal noise. By properly choosing the operating currents of Q1 and Q2 and separately sizing R1, low wideband noise is realized while maintaining 1 mW typical power dissipation.

## ORDERING GUIDE

| Model | Initial <br> Error <br> mV | Temperature <br> Coeff. <br> ppm $/{ }^{\circ} \mathrm{C}$ | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- | :--- | :--- |
| AD680JN | 10 | 25 | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Plastic | N-8 |
| AD680JR | 10 | 25 | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | SOIC | R-8 |
| AD680JT | 10 | 30 | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | TO-92 | TO-92 |
| AD680AN | 5 | 20 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Plastic | N-8 |
| AD680AR | 5 | 20 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | SOIC | R-8 |

[^111]
## FEATURES

$\pm 10 \mathrm{~V}$ Tracking Outputs
Kelvin Connections
Low Tracking Error - 1.5 mV
Low Initial Error - 2.0 mV
Low Drift - 1.5 ppm $/{ }^{\circ} \mathrm{C}$
Low Noise - $6 \mu \mathrm{~V}$ p-p
Flexible Output Force and Sense Terminals
High Impedance Ground Sense
Machine Insertable DIP Packaging
MIL-STD-883 Compliant Versions Available

## PRODUCT DESCRIPTION

The AD688 is a high precision $\pm 10 \mathrm{~V}$ tracking reference. Low tracking error, low initial error and low temperature drift give the AD688 reference absolute $\pm 10 \mathrm{~V}$ accuracy performance previously unavailable in monolithic form. The AD688 uses a proprietary ion-implanted buried Zener diode, and laser-wafer-drift-trimming of high stability thin-film resistors to provide outstanding performance at low cost.
The AD688 includes the basic reference cell and three additional amplifiers. The amplifiers are laser-trimmed for low offset and low drift and maintain the accuracy of the reference. The amplifiers are configured to allow Kelvin connections to the load and/or boosters for driving long lines or high current loads, delivering the full accuracy of the AD688 where it is required in the application circuit.

The low initial error allows the AD688 to be used as a system reference in precision measurement applications requiring 12 -bit absolute accuracy. In such systems, the AD688 can provide a known voltage for system calibration and the cost of periodic recalibration can therefore be eliminated. Furthermore, the mechanical instability of a trimming potentiometer and the potential for improper calibration can be eliminated by using the AD688 and calibration software.
The AD688 is available in three versions. The AD688AQ and BQ grades are packaged in 16-pin cerdip ( $0.3^{\prime \prime}$ ) packages and are specified for operation from $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. The AD688SQ grade is specified for operation from $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
*Protected by Patent Number 4,644,253.

FUNCTIONAL BLOCK DIAGRAM


## PRODUCT HIGHLIGHTS

1. The AD688 offers precision tracking $\pm 10 \mathrm{~V}$ Kelvin output connections with no external components. Tracking error is less than 1.5 mV and a fine-trim is available for applications requiring exact symmetry between the +10 V and -10 V outputs.
2. The AD688 offers 12-bit absolute accuracy without any user adjustments. Optional fine-trim connections are provided for applications requiring higher precision. The fine-trimming does not alter the operating conditions of the Zener or the buffer amplifiers and thus does not increase the temperature drift.
3. Output noise of the AD688 is low - typically $6 \mu \mathrm{~V} p-\mathrm{p}$. A pin is provided for broadband noise filtering using an external capacitor.
4. The AD688 is available in versions compliant with MIL-STD-883. Refer to the Analog Devices Military Products Databook or current AD688/883B data sheet for detailed specifications.

## AD688 - SPECIFICATIONS

(typical @ $+25^{\circ} \mathrm{C},+10 \mathrm{~V}$ output, $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}$ unless otherwise noted')

|  | AD688AQ/SQ |  |  | AD688BQ |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max |  |
| OUTPUT VOLTAGE ERROR $+10 \mathrm{~V},-10 \mathrm{~V}$ Outputs | -5 |  | +5 | -2 |  | +2 | mV |
| $\pm 10 \mathrm{~V}$ TRACKING ERROR | -3 |  | +3 | -1.5 |  | +1.5 | mV |
| $\begin{aligned} & \text { OUTPUT VOLTAGE DRIFT } \\ & +10 \mathrm{~V},-10 \mathrm{~V} \text { Outputs } \\ & 0 \text { to }+70^{\circ} \mathrm{C}(\mathrm{~A}, \mathrm{~B}) \\ & -40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C}(\mathrm{~A}, \mathrm{~B}) \\ & -55^{\circ} \mathrm{C} \text { to }+125^{\circ} \mathrm{C}(\mathrm{~S}) \end{aligned}$ | $\begin{aligned} & -3 \\ & -6 \end{aligned}$ | $\pm 2$ | $\begin{aligned} & +3 \\ & +6 \end{aligned}$ | $\begin{aligned} & -1.5 \\ & -3 \end{aligned}$ |  | $\begin{aligned} & +1.5 \\ & +3 \end{aligned}$ | ppm $/{ }^{\circ} \mathrm{C}$ <br> ppm $/{ }^{\circ} \mathrm{C}$ <br> $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ |
| $\begin{aligned} & \hline \text { GAIN ADJ AND BAL ADJ }{ }^{2} \\ & \text { Trim Range } \\ & \text { Input Resistance } \\ & \hline \end{aligned}$ |  | $\begin{aligned} & \pm 5 \\ & 150 \end{aligned}$ |  |  | $\begin{aligned} & \pm 5 \\ & 150 \end{aligned}$ |  | $\begin{aligned} & \mathrm{mV} \\ & \mathrm{k} \Omega \end{aligned}$ |
| LINE REGULATION $\mathrm{T}_{\min }$ to $\mathrm{T}_{\max }{ }^{3}$ | -200 |  | +200 | -200 |  | +200 | $\mu \mathrm{V} / \mathrm{V}$ |
| ```LOAD REGULATION \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) +10 V Output, \(0<\mathrm{I}_{\text {OUT }}<10 \mathrm{~mA}\) -10 V Output, \(-10<\mathrm{I}_{\text {OUT }}<0 \mathrm{~mA}\)``` |  |  | $\begin{aligned} & \pm 50 \\ & \pm 50 \end{aligned}$ |  |  | $\begin{aligned} & \pm 50 \\ & \pm 50 \end{aligned}$ | $\mu \mathrm{V} / \mathrm{mA}$ <br> $\mu \mathrm{V} / \mathrm{mA}$ |
| SUPPLY CURRENT <br> $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ <br> Power Dissipation |  | $\begin{aligned} & 9 \\ & 270 \end{aligned}$ | $\begin{aligned} & 12 \\ & 360 \end{aligned}$ |  | $\begin{aligned} & 9 \\ & 270 \end{aligned}$ | $\begin{aligned} & 12 \\ & 360 \end{aligned}$ | $\begin{aligned} & \mathrm{mA} \\ & \mathrm{~mW} \end{aligned}$ |
| OUTPUT NOISE (ANY OUTPUT) 0.1 Hz to 10 Hz Spectral Density, 100 Hz |  | $\begin{aligned} & 6 \\ & 140 \end{aligned}$ |  |  | $\begin{aligned} & 6 \\ & 140 \end{aligned}$ |  | $\begin{aligned} & \mu \mathrm{V} p-\mathrm{p} \\ & \mathrm{nV} / \sqrt{\mathrm{Hz}} \end{aligned}$ |
| LONG TERM STABILITY (@ + $25^{\circ} \mathrm{C}$ ) |  | 15 |  |  | 15 |  | ppm/1000 hours |
| BUFFER AMPLIFIERS <br> Offset Voltage <br> Offset Voltage Drift <br> Bias Current <br> Open Loop Gain <br> Output Current A3, A4 <br> Common Mode Rejection (A3, A4) $V_{\mathrm{CM}}=1 \mathrm{~V} p-\mathrm{p}$ <br> Short-Circuit Current | -10 | $\begin{aligned} & 100 \\ & 1 \\ & 20 \\ & 110 \end{aligned}$ | +10 | -10 | $\begin{aligned} & 100 \\ & 1 \\ & 20 \\ & 110 \\ & \\ & 100 \\ & 50 \end{aligned}$ | +10 | $\mu \mathrm{V}$ <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ <br> nA <br> dB <br> mA <br> dB <br> mA |
| TEMPERATURE RANGE <br> Specified Performance <br> A, B Grades <br> S Grade | $\begin{aligned} & -40 \\ & -55 \end{aligned}$ |  | $\begin{aligned} & +85 \\ & +125 \end{aligned}$ | -40 |  | +85 | $\begin{aligned} & { }^{\circ} \mathrm{C} \\ & { }^{\circ} \mathrm{C} \end{aligned}$ |

NOTES
${ }^{1}$ See Figure 2a for output configuration. Specifications tested using +10 V output unless otherwise indicated.
${ }^{2}$ Gain and balance adjustments guaranteed capable of trimming output voltage error and symmetry error to zero.
${ }^{3}$ Test Condition: $+\mathrm{V}_{\mathrm{S}}=+18 \mathrm{~V},-\mathrm{V}_{\mathrm{s}}=-18 \mathrm{~V} ;+\mathrm{V}_{\mathrm{S}}=+13.5 \mathrm{~V},-\mathrm{V}_{\mathrm{S}}=-13.5 \mathrm{~V}$.
Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS*

```
+V
Power Dissipation (+25'C)
    Q Package . . . . . . . . . . . . . . . . . . . . . . . . . . . }600\mathrm{ mW
Storage Temperature . . . . . . . . . . . . . . . - }6\mp@subsup{5}{}{\circ}\textrm{C}\mathrm{ to +150}\mp@subsup{}{}{\circ}\textrm{C
Lead Temperature (Soldering, 10 Seconds) . . . . . . . + +300 }\mp@subsup{}{}{\circ}\textrm{C
Package Thermal Resistance
    Q ( }\mp@subsup{|}{\textrm{JA}}{}/\mp@subsup{0}{\textrm{JC}}{\prime}
        120/35*}\textrm{C}/\textrm{W
Output Protection: All outputs safe if shorted to ground
```

Power Dissipation $\left(+25^{\circ} \mathrm{C}\right)$
Q Package$65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 Seconds) .....  $+300^{\circ} \mathrm{C}$$\mathrm{Q}\left(\theta_{\mathrm{IA}} / \theta_{\mathrm{IC}}\right)$$120 / 35^{\circ} \mathrm{C} / \mathrm{W}$

[^112]
## ORDERING GUIDE

| Part <br> Number | Initial <br> Error | Temperature <br> Coefficient | Temperature <br> Range $-{ }^{\circ} \mathrm{C}$ | Package <br> Option $^{2}$ |
| :--- | :--- | :--- | :--- | :--- |
| AD688AQ | 5 mV | $3 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ | -40 to +85 | $\mathrm{Q}-16$ |
| AD688BQ | 2 mV | $3 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ | -40 to $+85^{3}$ | $\mathrm{Q}-16$ |
| AD688SQ | 5 mV | $6 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ | -55 to +125 | $\mathrm{Q}-16$ |
| AD688/883B | $\star$ | $\star$ | -55 to +125 | $\star$ |

NOTE
${ }^{1}$ For details on grade and package offerings screened in accordance with MIL-STD-883, refer to the Analog Devices Military Products Databook or current AD688/883B data sheet.
${ }^{2} \mathrm{Q}=$ Cerdip. For outline information see Package Information section.
${ }^{3}$ Temperature coefficient specified from 0 to $+70^{\circ} \mathrm{C}$.
*Refer to AD688/883B military data sheet.

## PIN CONFIGURATION



NC PINS ARE USED AS TEST POINTS BY THE FACTORY. TO ENSURE PROPER OPERATION, DO NOT CONNECT ANYTHING TO THESE PINS.

## THEORY OF OPERATION

The AD688 consists of a buried Zener diode reference, amplifiers and associated thin-film resistors as shown in the block diagram of Figure 1. The temperature compensation circuitry provides the device with a temperature coefficient of $1.5 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ or less.

Amplifier Al performs several functions. Al primarily acts to amplify the Zener voltage to the required 20 volts. In addition, Al also provides for external adjustment of the 20 V output through Pin 5, the GAIN ADJUST. Using the bias compensation resistor between the Zener output and the noninverting input to A1, a capacitor can be added at the NOISE
REDUCTION pin (Pin 7) to form a low pass filter and reduce the noise contribution of the Zener to the circuit. Two matched $12 \mathrm{k} \Omega$ nominal thin-film resistors (R4 and R5) divide the 20 V output in half.
Ground sensing for the circuit is provided by Amplifier A2. The noninverting input (Pin 9) senses the system ground and forces the midpoint of resistors R4 and R5 to be a virtual ground. Pin 12 (BALANCE ADJUST) can be used for fine adjustment of this midpoint transfer.

Amplifiers A3 and A4 are internally compensated and are used to buffer the voltages at Pins 6 and 8 as well as to provide a full Kelvin output. Thus, the AD688 has a full Kelvin capability by providing the means to sense a system ground and provide forced and sensed outputs referenced to that ground.


Figure 1. AD688 Functional Block Diagram
$2.5 \mathrm{~V} / 3.0 \mathrm{~V}$

Pin-Programmable 2.5 V or 3.0 V Output Ultralow Drift: $3 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ max
High Accuracy: 2.5 V or $3.0 \mathrm{~V} \pm 1 \mathrm{mV}$ max
Low Noise: $100 \mathrm{nV} / \sqrt{\mathrm{Hz}}$
Noise Reduction Capability
Low Quiescent Current: 1 mA max
Output Trim Capability
Plug-In Upgrade for Present References
Temperature Output Pin
Series or Shunt Mode Operation ( $\mathbf{\pm 2 . 5}$ V, $\pm 3.0$ V)

## PRODUCT DESCRIPTION

The AD780 is an ultrahigh precision bandgap reference voltage which provides a 2.5 V or 3.0 V output from inputs between 4.0 V and 36 V . Low initial error and temperature drift combined with low output noise and the ability to drive any value of capacitance make the AD780 the ideal choice for enhancing the performance of high resolution ADCs and DACs and for any general purpose precision reference application. A unique low headroom design facilitates a 3.0 V output from a $5.0 \mathrm{~V} \pm 10 \%$ input, providing a $20 \%$ boost to the dynamic range of an ADC, over performance with existing 2.5 V references.
The AD780 can be used to source or sink up to 10 mA and can be used in series or shunt mode, thus allowing positive or negative output voltages without external components. This makes it suitable for virtually any high performance reference application. Unlike some competing references, the AD780 has no "region of possible instability." The part is stable under all load conditions when a $1 \mu \mathrm{~F}$ bypass capacitor is used on the supply.
A temperature output pin is provided on the AD780. This provides an output voltage that varies linearly with temperature, allowing the AD780 to be configured as a temperature transducer while providing a stable 2.5 V or 3.0 V output.

The AD780 is a pin-compatible performance upgrade for the LT1019(A)-2.5 and the AD680. The latter is targeted toward low power applications.
The AD780 is available in two grades in plastic DIP, SOIC and cerdip packages. The AD780AN, AD780AR, AD780BN and AD780BR are specified for operation from $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. The AD780SQ and AD780SQ/883B are specified for $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ operation.

| Parameter | AD780AN/AR/SQ |  |  | AD780BN/BR |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max |  |
| OUTPUT VOLTAGE |  |  |  |  |  |  |  |
| 2.5 V Out | 2.495 |  | 2.505 | 2.499 |  | 2.501 | Volts |
| 3.0 V Out | 2.995 |  | 3.005 | 2.999 |  | 3.001 | Volts |
| $\begin{aligned} & \text { OUTPUT VOLTAGE DRIFT }{ }^{1} \\ & -40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \\ & -55^{\circ} \mathrm{C} \text { to }+125^{\circ} \mathrm{C} \end{aligned}$ |  |  | $\begin{aligned} & 7 \\ & 20 \end{aligned}$ |  |  | 3 | $\begin{aligned} & \mathrm{ppm} /{ }^{\circ} \mathrm{C} \\ & \mathrm{ppm} /{ }^{\circ} \mathrm{C} \end{aligned}$ |
| LINE REGULATION <br> 2.5 V Output, $4 \mathrm{~V} \leq+\mathrm{V}_{\text {IN }} \leq 36 \mathrm{~V}$ <br> $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ <br> 3.0 V Output, $4.5 \mathrm{~V} \leq+\mathrm{V}_{\mathrm{IN}} \leq 36 \mathrm{~V}$ <br> $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |  |  | $\begin{aligned} & 10 \\ & 10 \end{aligned}$ |  |  | * | $\begin{aligned} & \mu \mathrm{V} / \mathrm{V} \\ & \mu \mathrm{~V} / \mathrm{V} \end{aligned}$ |
| $\begin{aligned} & \text { LOAD REGULATION, SERIES MODE } \\ & \text { Sourcing } 0<\mathrm{I}_{\text {OUT }}<10 \mathrm{~mA} \\ & \mathrm{~T}_{\text {MIN }} \text { to } \mathrm{T}_{\text {MAX }} \\ & \text { Sinking }-10<\mathrm{I}_{\text {OUT }}<0 \mathrm{~mA} \\ & -40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \\ & -55^{\circ} \mathrm{C} \text { to }+125^{\circ} \mathrm{C} \end{aligned}$ |  |  | $\begin{aligned} & 50 \\ & 75 \\ & 75 \\ & 75 \\ & 150 \end{aligned}$ |  |  |  | $\mu \mathrm{V} / \mathrm{mA}$ <br> $\mu \mathrm{V} / \mathrm{mA}$ <br> $\mu \mathrm{V} / \mathrm{mA}$ <br> $\mu \mathrm{V} / \mathrm{mA}$ <br> $\mu \mathrm{V} / \mathrm{mA}$ |
| LOAD REGULATION, SHUNT MODE $1<\mathrm{I}_{\text {SHUNT }}<10 \mathrm{~mA}$ |  |  | 75 |  |  | $\star$ | $\mu \mathrm{V} / \mathrm{mA}$ |
| $\begin{aligned} & \hline \text { QUIESCENT CURRENT, } 2.5 \text { V SERIES MODE } \\ & -40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \\ & -55^{\circ} \mathrm{C} \text { to }+125^{\circ} \mathrm{C} \\ & \hline \end{aligned}$ |  | $\begin{aligned} & 0.75 \\ & 0.8 \end{aligned}$ | $\begin{aligned} & 1.0 \\ & 1.3 \end{aligned}$ |  |  |  | $\begin{aligned} & \mathrm{mA} \\ & \mathrm{~mA} \end{aligned}$ |
| MINIMUM SHUNT CURRENT |  | 0.7 | 1.0 |  | * | * | mA |
| OUTPUT NOISE 0.1 Hz to 10 Hz Spectral Density, 100 Hz |  | $\begin{aligned} & 4 \\ & 100 \end{aligned}$ |  |  |  | * | $\begin{aligned} & \mu \mathrm{V} \mathrm{p}-\mathrm{p} \\ & \mathrm{nV} / \sqrt{\mathrm{Hz}} \end{aligned}$ |
| LONG TERM STABILITY ${ }^{3}$ |  | 20 |  |  | * |  | $\pm \mathrm{ppm} / 1000 \mathrm{Hr}$ |
| TRIM RANGE | 4.0 |  |  | * |  |  | $\pm \%$ |
| TEMPERATURE PIN <br> Voltage Output @ $25^{\circ} \mathrm{C}$ Temperature Sensitivity Output Resistance | 500 | $\begin{aligned} & 560 \\ & 1.9 \\ & 3 \end{aligned}$ | 620 | * | $\begin{aligned} & \star \\ & \star \end{aligned}$ | * | $\begin{aligned} & \mathrm{mV} \\ & \mathrm{mV} /{ }^{\circ} \mathrm{C} \\ & \mathrm{k} \Omega \end{aligned}$ |
| SHORT CIRCUIT CURRENT TO GROUND |  | 30 |  |  | * |  | mA |
| TEMPERATURE RANGE <br> Specified Performance (A, B) <br> Operating Performance (A, B) ${ }^{4}$ <br> Specified Performance (S) <br> Operating Performance ( S ) | $\begin{aligned} & -40 \\ & -55 \\ & -55 \\ & -55 \end{aligned}$ |  | $\begin{aligned} & +85 \\ & +125 \\ & +125 \\ & +125 \end{aligned}$ |  |  | * * * | $\begin{aligned} & { }^{\circ} \mathrm{C} \\ & { }^{\circ} \mathrm{C} \\ & { }^{\circ} \mathrm{C} \\ & { }^{\circ} \mathrm{C} \end{aligned}$ |

NOTES
${ }^{1}$ Maximum output voltage drift is guaranteed for all packages.
${ }^{2} 3.0 \mathrm{~V}$ mode typically adds $100 \mu \mathrm{~A}$ to the quiescent current. Also, Iq increases by $2 \mu \mathrm{~A} / \mathrm{V}$ above an input voltage of 5 V .
${ }^{3}$ The long term stability specification is noncumulative. The drift in subsequent 1000 hr . periods is significantly lower than in the first 1000 hr . period.
${ }^{4}$ The operating temperature range is defined as the temperature extremes at which the device will still function. Parts may deviate from their specified perfor-
mance outside their specified temperature range.
*Same as AD780AN/AR/SQ specification.
Specifications subject to change without notice.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD780 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


## ABSOLUTE MAXIMUM RATINGS*

$\mathrm{V}_{\text {IN }}$ to Ground . . . . . . . . . . . . . . . . . . . . . . . . . . . . 36 V
Trim Pin to Ground . . . . . . . . . . . . . . . . . . . . . . . . . 36 V
Temp Pin to Ground . . . . . . . . . . . . . . . . . . . . . . . . 36 V
Power Dissipation ( $25^{\circ} \mathrm{C}$ ) . . . . . . . . . . . . . . . . . . . 500 mW
Storage Temperature . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 sec ) . . . . . . . . . . . . . $300^{\circ} \mathrm{C}$ Output Protection: Output safe for indefinite short to ground and momentary short to $\mathrm{V}_{\mathrm{IN}}$.
ESD Classification
. Class 1 ( 1000 V )
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any conditions above those indicated in the operational specification is not implied. Exposure to absolute maximum specifications for extended periods may affect device reliability.

PIN CONFIGURATION 8-Pin Plastic DIP, SOIC and Cerdip Packages


## DIE LAYOUT



## NOTES

Both $\mathrm{V}_{\text {out }}$ pads should be connected to the output.
Die Thickness: The standard thickness of Analog Devices Bipolar dice is 24 mils $\pm 2$ mils.
Die Dimensions: The dimensions given have a tolerance of $\pm 2$ mils. Backing: The standard backside surface is silicon (not plated). Analog Devices does not recommend gold-backed dice for most applications. Edges: A diamond saw is used to separate wafers into dice thus providing perpendicular edges half-way through the die.
In contrast to scribed dice, this technique provides a more uniform die shape and size. The perpendicular edges facilitate handling (such as tweezer pick-up) while the uniform shape and size simplifies substrate design and die attach. Top Surface: The standard top surface of the die is covered by a layer of glassivation. All areas are covered except bonding pads and scribe lines. Surface Metalization: The metalization to Analog Devices bipolar dice is aluminum. Minimum thickness is $10,000 \AA$.
Bonding Pads: All bonding pads have a minimum size of 4.0 mils by 6.0 mils. The passivation windows have a 3.6 mils by 5.6 mils minimum size.

ORDERING GUIDE

| Model | Initial <br> Error | Temperature <br> Coefficient | Temperature <br> Range | Package <br> Option |
| :--- | :--- | :--- | :--- | :--- |
| AD780AN | 5 mV | $7 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| AD780AR | 5 mV | $7 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-8$ |
| AD780BN | 1 mV | $3 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| AD780BR | 1 mV | $3 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-8$ |
| AD780SQ | 5 mV | $20 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |
| AD780SQ/883B | 5 mV | $20 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |

*For outline information see Package Information section.

## THEORY OF OPERATION

Bandgap references are the high performance solution for low supply voltage and low power voltage reference applications. In this technique a voltage with a positive temperature coefficient is combined with the negative coefficient of a transistor's Vbe to produce a constant bandgap voltage.
In the AD780, the bandgap cell contains two npn transistors (Q6 and Q7) which differ in emitter area by $12 \times$. The difference in their Vbe's produces a PTAT current in R5. This in turn produces a PTAT voltage across R4, which when combined with the Vbe of Q7, produces a voltage Vbg that does not vary with temperature. Precision laser trimming of the resistors and other patented circuit techniques are used to further enhance the drift performance.


Figure 1. Schematic Diagram
The output voltage of the AD780 is determined by the configuration of resistors R13, R14 and R15 in the amplifier's feedback loop. This sets the output to either 2.5 V or 3.0 V depending on whether R15 (Pin 8) is grounded or not connected.
A unique feature of the AD780 is the low headroom design of the high gain amplifier which produces a precision 3 V output from an input voltage as low as 4.5 V (or 2.5 V from a 4.0 V input). The amplifier design also allows the part to work with $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\text {OUT }}$ when current is forced into the output terminal. This allows the AD780 to work as a two terminal shunt regulator providing a -2.5 V or -3.0 V reference voltage output without external components.

The PTAT voltage is also used to provide the user with a thermometer output voltage (at Pin 3) which increases at a rate of approximately $2 \mathrm{mV} /{ }^{\circ} \mathrm{C}$.
The AD780's NC Pin 7 is a $20 \mathrm{k} \Omega$ resistor to $\mathrm{V}+$ which is used solely for production test purposes. Users who are currently using the LT1019 self-heater pin (Pin 7) must take into account the different load on the heater supply.

## APPLYING THE AD780

The AD780 can be used without any external components to achieve specified performance. If power is supplied to Pin 2 and Pin 4 is grounded, Pin 6 provides a 2.5 V or 3.0 V output depending on whether Pin 8 is left unconnected or grounded.
A bypass capacitor of $1 \mu \mathrm{~F}$ ( $\mathrm{V}_{\text {IN }}$ to GND) should be used if the load capacitance in the application is expected to be greater than 1 nF . The AD780 in 2.5 V mode typically draws $700 \mu \mathrm{~A}$ of Iq at 5 V . This increases by $\sim 2 \mu \mathrm{~A} / \mathrm{V}$ up to 36 V .


Figure 2. Optional Fine Trim Circuit
Initial error can be nulled using a single $25 \mathrm{k} \Omega$ potentiometer connected between $V_{\text {OUT }}$, Trim and GND. This is a coarse trim with an adjustment range of $\pm 4 \%$ and is only included here for compatibility purposes with other references. A fine trim can be implemented by inserting a large value resistor (e.g. $1-5 \mathrm{M} \Omega$ ) in series with the wiper of the potentiometer. See Figure 2 above. The trim range, expressed as a fraction of the output, is simply greater than or equal to $2.1 \mathrm{k} \Omega / \mathrm{R}_{\mathrm{NULL}}$ for either the 2.5 V or 3.0 V mode.

The external null resistor affects the overall temperature coefficient by a factor equal to the percentage of $\mathrm{V}_{\text {OUT }}$ nulled.
For example a $1 \mathrm{mV}(.03 \%)$ shift in the output caused by the trim circuit, with a $100 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ null resistor will add less than $0.06 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ to the output drift $\left(0.03 \% \times 200 \mathrm{ppm} /{ }^{\circ} \mathrm{C}\right.$, since the resistors internal to the AD780 also have temperature coefficients of less than $100 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ ).

## NOISE PERFORMANCE

The impressive noise performance of the AD780 can be further improved if desired by the addition of two capacitors: a load capacitor Cl between the output and ground, and a compensation capacitor C2 between the TEMP pin and ground. Suitable values are shown in Figure 3.


Figure 3. Compensation and Load Capacitor Combinations
Cl and C 2 also improve the settling performance of the AD780 when subjected to load transients. The improvement in noise performance is shown in Figures 4, 5 and 6 following.


Figure 4. Stand-Alone Noise Performance


Figure 5. Noise Reduction Circuit

## NOISE COMPARISON

The wideband noise performance of the AD780 can also be expressed in ppm. The typical performance with $\mathrm{C} 1, \mathrm{C} 2$ is 0.6 ppm and without external capacitors is 1.2 ppm .

This performance is respectively $7 \times$ and $3 \times$ lower than the specified performance of the LT1019.

NO AMPLIFIER


10 Hz TO 10 kHz
Figure 6. Reduced Noise Performance with C1 $=100 \mu F$, $C 2=100 \mathrm{nF}$

## TEMPERATURE PERFORMANCE

The AD780 provides superior performance over temperature by means of a combination of patented circuit design techniques, precision thin film resistors and drift trimming. Temperature performance is specified in terms of $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$, but because of nonlinearity in the temperature characteristic, the Box-Test method is used to test and specify the part. The nonlinearity takes the form of the characteristic S-shaped curve shown in Figure 7. The Box-Test method forms a rectangular box around this curve, enclosing the maximum and minimum output voltages over the specified temperature range. The specified drift is equal to the slope of the diagonal of this box.


Figure 7. Typical AD780BN Temperature Drift

## TEMPERATURE OUTPUT PIN

The AD780 provides a "TEMP" output (Pin 3) that varies linearly with temperature. This output can be used to monitor changes in system ambient temperature and to initiate calibration of the system if desired.

The voltage $\mathrm{V}_{\text {TEMP }}$ is 560 mV at $25^{\circ} \mathrm{C}$, and the temperature coefficient is approximately $2 \mathrm{mV} /{ }^{\circ} \mathrm{C}$. Figure 8 following shows the typical $\mathrm{V}_{\text {TEMP }}$ characteristic curve over temperature.


Figure 8. Temperature Pin Transfer Characteristic
Since the TEMP voltage is acquired from the bandgap core circuit, current pulled from this pin will have an effect on $\mathrm{V}_{\text {out }}$ Care must be taken to buffer the TEMP output with a suitable op amp, e.g., an AD OP-07, AD820 or AD711 (all of which would result in less than a $100 \mu \mathrm{~V}$ change in $\mathrm{V}_{\text {out }}$ ). The relationship between $\mathrm{I}_{\text {TEMP }}$ and $\mathrm{V}_{\text {OUT }}$ is as follows:

$$
\begin{aligned}
& \Delta \mathrm{V}_{\text {OUT }}=5.8 \mathrm{mV} / \mu \mathrm{A} \times \mathrm{I}_{\text {TEMP }}(2.5 \mathrm{~V} \text { range }) \\
& \text { or } \\
& \Delta \mathrm{V}_{\text {OUT }}=6.9 \mathrm{mV} / \mu \mathrm{A} \times \mathrm{I}_{\text {TEMP }}(3.0 \mathrm{~V} \text { range })
\end{aligned}
$$

## TEMPERATURE TRANSDUCER CIRCUIT

The circuit shown in Figure 9 is a temperature transducer which amplifies the TEMP output voltage by a gain of a little over 5 to provide a wider full scale output range. The trimpot can be used to adjust the output so it varies exactly by $10 \mathrm{mV} /{ }^{\circ} \mathrm{C}$.
To minimize resistance changes with temperature, resistors with low temperature coefficients, such as metal film resistors should be used.


Figure 9. Differential Temperature Transducer

## SUPPLY CURRENT OVER TEMPERATURE

The AD780's quiescent current will vary slightly over temperature and input supply range. The test limit is 1 mA over the industrial and 1.3 mA over the military temperature range. Typical performance with input voltage and temperature variation is shown in Figure 10 following.


Figure 10. Typical Supply Current over Temperature

## TURN-ON TIME

The time required for the output voltage to reach its final value within a specified error band is defined as the turn-on settling time. The two major factors that affect this are the active circuit settling time and the time for the thermal gradients on the chip to stabilize. Typical settling performance is shown in Figure 11 following. The AD780 settles to within $0.1 \%$ of its final value within $10 \mu \mathrm{~s}$.


Figure 11. Turn-On Settling Time Performance

## DYNAMIC PERFORMANCE

The output stage of the AD780 has been designed to provide superior static and dynamic load regulation.
Figure 12 shows the performance of the AD780 while driving a 0 mA to 10 mA load.


Figure 12a. Transient Resistive Load Test Circuit


Figure 12b. Settling Under Transient Resistive Load
The dynamic load may be resistive and capacitive. For example the load may be connected via a long capacitive cable. Figure 13 following shows the performance of the AD780 driving a $1000 \mathrm{pF}, 0 \mathrm{~mA}$ to 10 mA load.


Figure 13a. Capacitive Load Transient Response Test Circuit


Figure 13b. Settling Under Dynamic Capacitive Load

## LINE REGULATION

Line regulation is a measure of the change in output voltage due to a specified change in input voltage. It is intended to simulate worst case unregulated supply conditions and is measured in $\mu \mathrm{V} / \mathrm{V}$. Figure 14 shows typical performance with $4.0 \mathrm{~V}<\mathrm{V}_{\mathrm{IN}}$ $<15.0 \mathrm{~V}$.


Figure 14. Output Voltage Change vs. Input Voltage

## PRECISION REFERENCE FOR HIGH RESOLUTION +5 V DATA CONVERTERS

The AD780 is ideally suited to be the reference for most +5 V high resolution ADCs. The AD780 is stable under any capacitive load, it has superior dynamic load performance, and the 3.0 V output provides the converter with maximum dynamic range without requiring an additional and expensive buffer amplifier. One of the many ADCs that the AD780 is suited for is the AD7884, a 16-bit, high speed sampling ADC. (See Figure 15.) This part previously needed a precision 5.0 V reference, resistor divider and buffer amplifier to do this function.


Figure 15. Precision 3.0 V Reference for the AD7884 16-Bit, High Speed ADC

The AD780 is also ideal for use with higher resolution converters such as the AD7710/AD7711/AD7712. (See Figure 16.) While these parts are specified with a 2.5 V internal reference, the AD780 in 3 V mode can be used to improve the absolute accuracy, temperature stability and dynamic range. It is shown following with the two optional noise reduction capacitors.


Figure 16. Precision 2.5 V or 3.0 V Reference for the AD7710 High Resolution, Sigma-Delta ADC

## +4.5 V REFERENCE FROM +5 V SUPPLY

Some +5 V high resolution ADCs can accommodate reference voltages up to +4.5 V . The AD780 can be used to provide a precision +4.5 V reference voltage from a +5 V supply using the circuit shown following in Figure 17. This circuit will provide a regulated +4.5 V output from a supply voltage as low as +4.7 V . The high quality tantalum $10 \mu \mathrm{~F}$ capacitor in parallel with the ceramic $0.1 \mu \mathrm{~F}$ capacitor and the $3.9 \Omega$ resistor ensure a low output impedance up to around 50 MHz .


Figure 17. $+4.5 V$ Reference from a Single $+5 V$ Supply
NEGATIVE ( $\mathbf{- 2 . 5} \mathbf{V}$ OR $\mathbf{- 3 . 0} \mathrm{V}$ ) REFERENCE
The AD780 can produce a negative output voltage in shunt mode, simply by connecting the input and output to ground and connecting the AD780's GND pin to a negative supply via a bias resistor as shown in Figure 18.


Figure 18. Negative ( -2.5 V) Shunt Mode Reference

A precise -2.5 V (or -3.0 V ) reference capable of supplying up to 100 mA to a load can be implemented with the AD780 in series mode using the bootstrap circuit following.


Figure 19. -2.5 V High Load Current Reference

## FEATURES

Improved, Lower Cost, Replacements for Standard 1403, 1403A
3-Terminal Device: Voltage In/Voltage Out
Laser Trimmed to High Accuracy: $2.500 \mathrm{~V} \pm 10 \mathrm{mV}$ (AD1403A)
Excellent Temperature Stability: 25ppm/ ${ }^{\circ} \mathrm{C}$ (AD1403A)
Low Quiescent Current: 1.5mA max
10mA Current Output Capability
Low Cost
Convenient Mini-DIP Package

FUNCTIONAL BLOCK DIAGRAM


## PRODUCT DESCRIPTION

The AD1403 and AD1403A are improved three-terminal, low cost, temperature compensated, bandgap voltage references that provide a fixed 2.5 V output voltage for inputs between 4.5 V and 40 V . A unique combination of advanced circuit design and laser-wafer-trimmed thin-film resistors provides the AD1403/AD1403A with an initial tolerance of $\pm 10 \mathrm{mV}$ and a temperature stability of better than $25 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$. In addition, the low quiescent current drain of 1.5 mA (max) offers a clear advantage over classical Zener techniques.
The AD1403 or AD1403A is recommended as a stable reference for all 8 -, 10 - and 12 -bit D-to-A converters that require an external reference. In addition, the wide input range of the AD1403/AD1403A allows operation with 5 volt logic supplies, making these devices ideal for digital panel meter applications and when only a single logic supply is available.
The AD1403 and AD1403A are specified for operation over the 0 to $+70^{\circ} \mathrm{C}$ temperature range. The AD580 series of 2.5 volt precision IC references is recommended for applications where operation over the $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ range is required.

## PRODUCT HIGHLIGHTS

1. The AD1403A offers improved initial tolerance over the industry-standard $1403 \mathrm{~A}: \pm 10 \mathrm{mV}$ versus $\pm 25 \mathrm{mV}$ at a lower cost.
2. The three-terminal voltage in/voltage out operation of the AD1403/AD1403A provides a regulated output voltage without any external components.
3. The AD1403/AD1403A provides a stable 2.5 V output voltage for input voltages between 4.5 V and 40 V making these devices ideal for systems that contain a single logic supply.
4. Thin film resistor technology and tightly controlled bipolar processing provide the AD1403A with temperature stabilities of $25 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$.
5. The low 1.5 mA maximum quiescent current drain of the AD1403 and AD1403A makes them ideal for CMOS and other low power applications.
[^113][^114]SPEGMFARTONG $\left(V_{W}=15 V, T_{A}=25^{\circ} \mathrm{C}\right.$ unless otherwise noted.)

| Characteristic | Symbol | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Output Voltage $\begin{aligned} & \left(\mathrm{I}_{\mathrm{O}}=0 \mathrm{~mA}\right) \\ & \text { AD1403 } \\ & \text { AD1403A } \end{aligned}$ | $\mathrm{V}_{0}$ | $\begin{array}{\|l\|l\|} 2.475 \\ 2.490 \end{array}$ | $\begin{aligned} & 2.500 \\ & 2.500 \end{aligned}$ | $\begin{aligned} & 2.525 \\ & 2.510 \end{aligned}$ | V |
| Temperature Coefficient of Output Voltage <br> AD1403 <br> AD1403A | $\Delta \mathrm{V}_{\mathrm{O}} / \Delta \mathrm{T}$ | - | $\begin{aligned} & 10 \\ & 10 \end{aligned}$ | $\begin{aligned} & 40 \\ & 25 \end{aligned}$ | ppm/ ${ }^{\circ} \mathrm{C}$ |
| Output Voltage Change, 0 to $+70^{\circ} \mathrm{C}$ AD1403 <br> AD1403A | $\Delta \mathrm{V}_{\mathbf{O}}$ | - | - | $\begin{aligned} & 7.0 \\ & 4.4 \end{aligned}$ | mV |
| $\begin{aligned} & \text { Line Regulation } \\ & \left(15 \mathrm{~V} \leqslant \mathrm{~V}_{\text {IN }} \leqslant 40 \mathrm{~V}\right) \\ & \left(4.5 \leqslant \mathrm{~V}_{\text {IN }} \leqslant 15 \mathrm{~V}\right) \\ & \hline \end{aligned}$ | $\mathrm{Reg}_{\text {in }}$ | - | $\begin{aligned} & 1.2 \\ & 0.6 \\ & \hline \end{aligned}$ | $\begin{array}{r} 4.5 \\ 3.0 \\ \hline \end{array}$ | mV |
| Load Regulation $\left(0 \mathrm{~mA}<\mathrm{I}_{\mathrm{O}}<10 \mathrm{~mA}\right)$ | Reg ${ }_{\text {load }}$ | - | - | 10 | mV |
| Quiescent Current $\left(\mathrm{I}_{\mathrm{O}}=0 \mathrm{~mA}\right)$ | $\mathrm{I}_{1}$ | - | 1.2 | 1.5 | mA |

Specifications subject to change without notice.

| MAXIMUM RATINGS ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise noted) |  |  |  |
| :---: | :---: | :---: | :---: |
| Rating | Symbol | Value | Unit |
| Input Voltage | $\mathrm{V}_{\text {IN }}$ | 40 | V |
| Storage Temperature | T ${ }_{\text {STG }}$ | -25 to 100 | ${ }^{\circ} \mathrm{C}$ |
| Junction Temperature | $\mathrm{T}_{\mathrm{J}}$ | +175 | ${ }^{\circ} \mathrm{C}$ |
| Operating Ambient Temperature Range | $\mathrm{T}_{\mathrm{A}}$ | 0 to +70 | ${ }^{\circ} \mathrm{C}$ |

ORDERING GUIDE

| Model | Initial <br> Tolerance | Package <br> Option <br>  <br> AD1403 |
| :--- | :--- | :--- |
| AD1403A | $\pm 25 \mathrm{mV}$ | $\mathrm{N}-8$ |
|  | $\pm 10 \mathrm{mV}$ | $\mathrm{N}-8$ |

* $\mathrm{N}=$ Plastic DIP. For outline information see Package Information section.


Figure 1. Simplified AD1403 Schematic ADM663/ADM666

## FEATURES

5 V Fixed or +1.3 V to +16 V Adjustable Low Power CMOS: $12 \mu \mathrm{~A}$ max Quiescent Current 40 mA Output Current
Current Limiting
Pin Compatible with MAX663/666
+2 V to +16.5 V Operating Range
Low Battery Detector ADM666
No Overshoot on Power-Up

## APPLICATIONS

Handheld Instruments
LCD Display Systems
Pagers
Remote Data Acquisition

## GENERAL DESCRIPTION

The ADM663/ADM666 are precision voltage regulators featuring a maximum quiescent current of $12 \mu \mathrm{~A}$. They can be used to give a fixed +5 V output with no additional external components or can be adjusted from 1.3 V to 16 V using two external resistors. Fixed or adjustable operation is automatically selected via the $\mathrm{V}_{\mathrm{SET}}$ input. The low quiescent current makes these devices especially suitable for battery powered systems. The input voltage range is 2 V to 16.5 V and an output current up to 40 mA is provided. The ADM663 can directly drive an external pass transistor for currents in excess of 40 mA . Additional features include current limiting and low power shutdown. Thermal shutdown circuitry is also included for additional safety.
The ADM666 features additional low battery monitoring circuitry to detect for low battery voltages.
The ADM663/ADM666 are pin-compatible replacements for the MAX663/666. Both are available in 8-pin DIP and in narrow surface mount (SOIC) packages.

## ORDERING GUIDE

| Model | Temperature Range | Package Option» |
| :--- | :--- | :--- |
| ADM663AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| ADM663AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-8$ |
| ADM666AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| ADM666AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-8$ |

[^115]
## FUNCTIONAL BLOCK DIAGRAMS



| Parameter | Min | Typ | Max | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Quiescent Current, $\mathrm{I}_{\mathrm{Q}}$ | 2.0 |  | 16.5 | V | $\begin{aligned} & \mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{MIN}} \text { to } \mathrm{T}_{\mathrm{MAX}} \\ & \text { No Load, } \mathrm{V}_{\mathrm{IN}}=+16.5 \mathrm{~V} \end{aligned}$ |
|  |  | 6 | 12 | $\mu \mathrm{A}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |
|  |  |  | 15 | $\mu \mathrm{A}$ | $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |
| Output Voltage, $\mathrm{V}_{\text {Out }}$ | 4.75 | 5.0 | 5.25 | V | $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}, \mathrm{V}_{\text {SET }}=\mathrm{GND}$ |
| Line Regulation, $\Delta \mathrm{V}_{\text {OUT }} / \Delta \mathrm{V}_{\mathrm{IN}}$ |  | 0.03 | 0.35 | \%/V | $+2 \mathrm{~V} \leq \mathrm{V}_{\text {IN }} \leq+15 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=\mathrm{V}_{\text {REF }}$ |
| Load Regulation, $\Delta \mathrm{V}_{\text {OUT }} / \Delta \mathrm{I}_{\text {OUT }}$ |  | 3.0 | 7.0 | $\Omega$ | ADM663, $1 \mathrm{~mA} \leq \mathrm{I}_{\text {OUT } 2} \leq 20 \mathrm{~mA}$ |
|  |  | 1.0 | 5.0 | $\Omega$ | ADM663, $50 \mu \mathrm{~A} \leq \mathrm{I}_{\text {OUT }} \leq 5 \mathrm{~mA}$ |
|  |  | 3.0 | 7.0 | $\Omega$ | ADM666, $1 \mathrm{~mA} \leq \mathrm{I}_{\text {OUT }} \leq 20 \mathrm{~mA}$ |
| Reference Voltage, $\mathrm{V}_{\text {SET }}$ | 1.27 |  | 1.33 | V | $\mathrm{V}_{\text {OUT }}=\mathrm{V}_{\text {SET }}$ |
| Reference Tempco, $\Delta \mathrm{V}_{\mathrm{SET}} / \Delta \mathrm{T}$ |  | $\pm 100$ |  | ppm/ ${ }^{\circ} \mathrm{C}$ | $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |
| $\mathrm{V}_{\text {SET }}$ Internal Threshold, $\mathrm{V}_{\text {F/A }}$ |  | 50 |  | mV | $\mathrm{V}_{\mathrm{SET}}<\mathrm{V}_{\mathrm{FA}}$ for +5 V Out; <br> $\mathrm{V}_{\text {SET }}>\mathrm{V}_{\text {F/A }}$ for Adj. Out |
| $\mathrm{V}_{\text {SET }}$ Input Current, $\mathrm{I}_{\text {SET }}$ |  | $\pm 0.01$ | $\pm 10$ | nA | $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |
| Shutdown Input Voltage, $\mathrm{V}_{\text {SHDN }}$ | 1.4 |  |  | V | $\mathrm{V}_{\text {SHDN }}$ High $=$ Output Off |
|  |  |  | 0.3 | V | $\mathrm{V}_{\text {SHDN }}$ Low $=$ Output On |
| Shutdown Input Current, $\mathrm{I}_{\text {SHDN }}$ |  | $\pm 0.01$ | $\pm 10$ | nA |  |
| SENSE Input Threshold, $\mathrm{V}_{\text {OUT }}-\mathrm{V}_{\text {SENSE }}$ |  | 0.5 |  | V | Current Limit Threshold |
| SENSE Input Resistance, $\mathrm{R}_{\text {SENSE }}$ |  | 3 |  | $\mathrm{M} \Omega$ |  |
| Input-Output Saturation Resistance, $\mathrm{R}_{\mathrm{SAT}}$ ADM663 Vout1 |  |  |  |  |  |
|  |  | 70 | 500 150 | $\Omega$ $\Omega$ | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=+2 \mathrm{~V}, \mathrm{I}_{\mathrm{OUT}}=1 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{IN}}=+9 \mathrm{~V}, \mathrm{I}_{\mathrm{OUT}}=2 \mathrm{~mA} \end{aligned}$ |
|  |  | 50 | 150 | $\Omega$ | $\mathrm{V}_{\text {IN }}=+15 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=5 \mathrm{~mA}$ |
| Output Current from $\mathrm{V}_{\text {Out }}$ (2), $\mathrm{I}_{\text {OUT }}$ | 40 |  |  | mA | $+3 \mathrm{~V} \leq \mathrm{V}_{\text {IN }} \leq+16.5 \mathrm{~V}, \mathrm{~V}_{\text {IN }}-\mathrm{V}_{\text {OUT }}=+1.5 \mathrm{~V}$ |
| Minimum Load Current, $\mathrm{I}_{\text {L (MIN) }}$ |  |  | 1.0 | $\mu \mathrm{A}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |
|  |  |  | 5.0 | $\mu \mathrm{A}$ | $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |
| LBI Input Threshold, $\mathrm{V}_{\text {LBI }}$ | 1.21 | 1.28 | 1.37 | V | ADM666 |
| LBI Input Current, $\mathrm{I}_{\text {LBI }}$ |  | $\pm 0.01$ | $\pm 10$ | nA | ADM666 |
| LBO Output Saturation Resistance, $\mathrm{R}_{\text {SAT }}$ |  | 35 | 100 | $\Omega$ | ADM666, $\mathrm{I}_{\text {SAT }}=2 \mathrm{~mA}$ |
| LBO Output Leakage Current |  | 10 |  | nA | ADM666, LBI $=1.4 \mathrm{~V}$ |
| $\mathrm{V}_{\text {TC }}$ Open Circuit Voltage, $\mathrm{V}_{\text {TC }}$ |  | 0.9 |  | V | ADM663 |
| $\mathrm{V}_{\text {TC }}$ Sink Current, $\mathrm{I}_{\text {TC }}$ | 2.0 | 8.0 |  | mA | ADM663 |
| $\mathrm{V}_{\text {TC }}$ Temperature Coefficient |  | +2.5 |  | $\mathrm{mV} /{ }^{\circ} \mathrm{C}$ | ADM663 |

Specifications subject to change without notice.
ABSOLUTE MAXIMUM RATINGS*( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)
Input Voltage, $\mathrm{V}_{\mathrm{IN}}$ ..... $+18 \mathrm{~V}$
Terminal Voltage
(ADM663) Pins 1, 3, 5, 6, 7
(GND $-0.3 \mathrm{~V})$ to $\left(\mathrm{V}_{\mathrm{IN}}+0.3 \mathrm{~V}\right)$
(ADM666) Pins 1, 2, 3, 5, 6
. . . . . . . . . . . . . . . . . . . . (GND -0.3 V ) to ( $\mathrm{V}_{\text {IN }}+0.3 \mathrm{~V}$ )
(ADM663) Pin $2 \ldots \ldots .(\mathrm{GND}-0.3 \mathrm{~V})$ to $\left(\mathrm{V}_{\text {OUT } 1}+0.3 \mathrm{~V}\right)$
(ADM666) Pin 7 (GND -0.3 V ) to +16.5 V
Output Source Current
(ADM663, ADM666) Pin 2 ..... 50 mA
(ADM663) Pin 3 ..... 25 mA
Output Sink Current,
(ADM663, ADM666) Pin 7 ..... $-20 \mathrm{~mA}$
Power Dissipation, N-8 ..... 625 mW
(Derate $8.3 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+50^{\circ} \mathrm{C}$ )
$\theta_{\mathrm{JA}}$, Thermal Impedance ..... $120^{\circ} \mathrm{C} / \mathrm{W}$
Power Dissipation R-8 ..... 450 mW
(Derate $6 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+50^{\circ} \mathrm{C}$ )$\theta_{\mathrm{JA}}$, Thermal Impedance$170^{\circ} \mathrm{C} / \mathrm{W}$
Operating Temperature Range Industrial (A Version) ..... $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range ..... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 sec ) ..... $+300^{\circ} \mathrm{C}$
Vapor Phase ( 60 sec ) ..... $+215^{\circ} \mathrm{C}$
Infrared (15 sec) ..... $+220^{\circ} \mathrm{C}$
ESD Rating ..... $>5000$ V
*This is a stress rating only and functional operation of the device at these or anyother conditions above those indicated in the operation sections of this specifica-tion is not implied. Exposure to absolute maximum rating conditions for extendedperiods of time may affect reliability.

DIP \& SOIC PIN CONFIGURATIONS


GND
LBI
LBO
SHDN
$\mathrm{V}_{\mathrm{SET}}$
$\mathrm{V}_{\mathrm{TC}}$

## GENERAL INFORMATION

The ADM663/ADM666 contains a micropower bandgap reference voltage source, an error amplifier A1, two comparators $\mathrm{C} 1, \mathrm{C} 2$ and a series pass output transistor. A P-channel FET and an NPN transistor are used on the ADM663 while the ADM666 uses an NPN output transistor.

## CIRCUIT DESCRIPTION

The internal bandgap reference is trimmed to $1.3 \mathrm{~V} \pm 30 \mathrm{mV}$. This is used as a reference input to the error amplifier A1. The feedback signal from the regulator output is supplied to the other input by an on-chip voltage divider or by two external resistors. When $\mathrm{V}_{\text {SET }}$ is at ground, the internal divider provides the error amplifier's feedback signal giving a +5 V output. When $\mathrm{V}_{\mathrm{SET}}$ is at more than 50 mV above ground, the error amplifier's input is switched directly to the $\mathrm{V}_{\text {SET }}$ pin, and external resistors are used to set the output voltage. The external resistors are selected so that the desired output voltage gives 1.3 V at $\mathrm{V}_{\mathrm{SET}}$.
Comparator C 1 monitors the output current via the SENSE input. This input, referenced to $\mathrm{V}_{\text {OUT(2), }}$, monitors the voltage drop across a load sense resistor. If the voltage drop exceeds 0.5 V , then the error amplifier $\mathrm{A}_{1}$ is disabled and the output current is limited.

The ADM663 has an additional amplifier, A2, which provides a temperature-proportional output, $\mathrm{V}_{\mathrm{TC}}$. If this is summed into the inverting input of the error amplifier, a negative temperature coefficient results at the output. This is useful when powering liquid crystal displays over wide temperature ranges.
The ADM666 has an additional comparator, C 3 which compares the voltage on the Low Battery Input, LBI, pin to the internal +1.3 V reference. The output from the comparator drives

PIN FUNCTION DESCRIPTION

| Mnemonic | Function |
| :--- | :--- |
| V OUT(1) (2) | Voltage Regulator Output(s) <br> Voltage Regulator Input <br> V |
| SENSE | Current Limit Sense Input. (Referenced to <br> $\mathrm{V}_{\text {OUT(2). }}$ ) If not used it should be connected to <br> $\mathrm{V}_{\text {out(2) }}$ <br> Ground Pin. Must be connected to 0 V |
| GND | Low Battery Detect Input. Compared with 1.3 V <br> LBI |
| LBO | Low Battery Detect Output. Open Drain Output <br> Digital Input. May be used to disable the device <br> so that the power consumption is minimized <br> Voltage Setting Input. Connect to GND for +5 V <br> output or connect to resistive divider for adjust |
| SHDN |  |
| able output |  |
| Temperature-Proportional Voltage for negative |  |
| TC Output |  |

an open drain FET connected to the Low Battery Output pin, LBO. The Low Battery Threshold may be set using a suitable voltage divider connected to LBI. When the voltage on LBI falls below 1.3 V , the open drain output LBO is pulled low.
Both the ADM663 and the ADM666 contain a shutdown (SHDN) input which can be used to disable the error amplifier and hence the voltage output. The quiescent current in shutdown is less than $12 \mu \mathrm{~A}$.


Figure 1. ADM663 Functional Block Diagram


Figure 2. ADM666 Functional Block Diagram

## Circuit Configurations

For a fixed +5 V output the $\mathrm{V}_{\text {SET }}$ input is grounded and no external resistors are necessary. This basic configuration is shown in Figure 3. Current limiting is not being utilized so the SENSE input is connected to $\mathrm{V}_{\text {Out }(2) \text {. The input voltage can range from }}$ +6 V to +16 V and output currents up to 40 mA are available provided that the maximum package power dissipation is not exceeded.


Figure 3. ADM663/ADM666 Fixed +5 V Output

## Output Voltage Setting

If $\mathrm{V}_{\text {SET }}$ is not connected to GND, the output voltage is set according to the following equation.

$$
V_{\text {OUT }}=V_{S E T} \times \frac{R 1+R 2}{R 1} \text { where } V_{S E T}=1.30 \mathrm{~V}
$$

The resistor values may be selected by firstly choosing a value for R1 and then selecting R2 according to the following equation.

$$
R 2=R 1 \times\left(\frac{V_{O U T}}{1.30}-1\right)
$$

The input leakage current on $\mathrm{V}_{\text {SET }}$ is 10 nA maximum. This allows large resistor values to be chosen for R1 and R2 with little degradation in accuracy. For example, a $1 \mathrm{M} \Omega$ resistor may be selected for R1 and then R2 may be calculated accordingly. The tolerance on $V_{\text {SET }}$ is guaranteed at less than $\pm 30 \mathrm{mV}$ so in most applications, fixed resistors will be suitable.


Figure 4. ADM663/ADM666 Adjustable Output

## Current Limiting

Current limiting may be achieved by using an external current sense resistor in series with $\mathrm{V}_{\text {OUT }(2)}$. When the voltage across the sense resistor exceeds the internal 0.5 V threshold, current limiting is activated. The sense resistor is therefore chosen such that the voltage across it will be 0.5 V when the desired current limit is reached.

$$
R_{C L}=\frac{0.5}{I_{C L}}
$$

where $\mathrm{R}_{\mathrm{CL}}$ is the current sense resistor, $\mathrm{I}_{\mathrm{CL}}$ is the maximum current limit.
The value chosen for $\mathrm{R}_{\mathrm{CL}}$ should also ensure that the current is limited to less than the 50 mA absolute maximum rating and also that the power dissipation will also be within the package maximum ratings.
If current limiting is employed, there will be an additional voltage drop across the sense resistor which must be considered when determining the regulators dropout voltage.
If current limiting is not used, the SENSE input should be connected to $V_{\text {out(2) }}$.

## Shutdown Input (SHDN)

The SHDN input allows the regulator to be switched off with a logic level signal. This will disable the output and reduce the current drain to a low quiescent ( $12 \mu \mathrm{~A}$ maximum) current. This is very useful for low power applications. The SHDN input should be driven with a CMOS logic level signal since the input threshold is 0.3 V . In TTL systems, an open collector driver with a pull-up resistor may be used.
If the shutdown function is not being used, then SHDN should be connected to GND.

## Low Supply or Low Battery Detection

The ADM666 contains on-chip circuitry for low power supply or battery detection. If the voltage on the LBI pin falls below the internal 1.3 V reference, then the open drain output LBO will go low. The low threshold voltage may be set to any voltage above 1.3 V by appropriate resistor divider selection.

$$
R 3=R 4 \times\left(\frac{V_{B A T T}}{1.30}-1\right)
$$

where $R 3$ and $R 4$ are the resistive divider resistors and $V_{\text {BATT }}$ is the desired low voltage threshold.

## ADM663/ADM666

Since the LBI input leakage current is less than 10 nA , large values may be selected for R3 and R4 in order to minimize loading. For example, a 6 V low threshold, may be set using $10 \mathrm{M} \Omega$ for R3 and $2.7 \mathrm{M} \Omega$ for R4.


Figure 5. ADM666 Adjustable Output with Low Battery Detection

## High Current Operation

The ADM663 contains an additional output, $V_{\text {OUT1 }}$, suitable for directly driving the base of an external NPN transistor. Figure 6 shows a configuration which can be used to provide +5 V with boosted current drive. A $1 \Omega$ current sensing resistor limits the current at 0.5 A .


Figure 6. ADM663 Boosted Output Current (0.5 A)

## Temperature Proportional Output

The ADM663 contains a $V_{T C}$ output with a positive temperature coefficient of $+2.5 \mathrm{mV} /{ }^{\circ} \mathrm{C}$. This may be connected to the summing junction of the error amplifier ( $\mathrm{V}_{\mathrm{SET}}$ ) through a resistor resulting in a negative temperature coefficient at the output of the regulator.
This is especially useful in multiplexed LCD displays to compensate for the inherent negative temperature coefficient of the LCD threshold. At $25^{\circ} \mathrm{C}$ the voltage at the VTC output is typically 0.9 V . The equations for setting both the output voltage and the tempco are given below. If this function is not being used, then $\mathrm{V}_{\mathrm{TC}}$ should be left unconnected.


Figure 7. ADM663 Temperature Proportional Output

$$
\begin{gathered}
V_{O U T}=V_{S E T} \times\left(1+\frac{R 2}{R 1}\right)+\frac{R 2}{R 3} \times\left(V_{S E T}-V_{T C}\right) \\
T C V_{O U T}=\frac{-R 2}{R 3} \times T V C_{T C}
\end{gathered}
$$

where $V_{S E T}=+1.3 \mathrm{~V}, V_{T C}=+0.9 \mathrm{~V}, T C V_{T C}=+2.5 \mathrm{mV} /{ }^{\circ} \mathrm{C}$

## APPLICATION HINTS

## Input-Output (Dropout Voltage)

A regulator's minimum input-output differential or dropout voltage determines the lowest input voltage for a particular output voltage. The ADM663/ADM666 dropout voltage is 0.8 V at its rated output current. For example when used as a fixed +5 V regulator the minimum input voltage is +5.8 V . At lower output currents, ( $\mathrm{I}_{\text {OUT }}<5 \mathrm{~mA}$ ), on the ADM663, $\mathrm{V}_{\text {OUT1 }}$ may be used as the output driver in order to achieve lower dropout voltages. Please refer to Figure 9. In this case the dropout voltage depends on the voltage drop across the internal FET transistor. This may be calculated by multiplying the FET's saturation resistance by the output current. As the current limit circuitry is referenced to $\mathrm{V}_{\text {OUT2 }}, \mathrm{V}_{\text {OUT2 }}$ should be connected to $\mathrm{V}_{\text {OUT1 }}$. For high current operation $V_{\text {OUT2 }}$ should be used alone and $\mathrm{V}_{\text {OUT1 }}$ left unconnected.

## Bypass Capacitors

The high frequency performance of the ADM663/ADM666 may be improved by decoupling the output using a filter capacitor. A capacitor value of $10 \mu \mathrm{~F}$ is suitable.
An input capacitor helps reduce noise and improves dynamic performance. A suitable input capacitor of $0.1 \mu \mathrm{~F}$ or greater may be used.


Figure 8. Power Supply Rejection Ratio vs. Frequency


Figure 9. Voutı Input-Output Differential vs. Output Current


Figure 10. Quiescent Current vs. Input Voltage


Figure 11. Vout(2) Input-Output Differential vs. Output Current

## ADM663AADM666A*

## FEATURES

Tri-Mode Operation
3.3 V, 5 V Fixed or +1.3 V to +16 V Adjustable

Low Power CMOS: $9 \mu \mathrm{~A}$ max Quiescent Current
High Current 100 mA Output
Low Dropout Voltage
Upgrade for ADM663/ADM666
"Small" $0.1 \mu \mathrm{~F}$ Output Capacitor ( 0805 Style)
+2 V to +16.5 V Operating Range
Low Battery Detector ADM666A
No Overshoot on Power-Up
Thermal Shutdown

## APPLICATIONS

Handheld Instruments
LCD Display Systems
Pagers
Battery Operated Equipment

## GENERAL DESCRIPTION

The ADM663A/ADM666A are precision linear voltage regulators featuring a maximum quiescent current of $9 \mu \mathrm{~A}$. They can be used to give a fixed +3.3 V or +5 V output with no additional external components or can be adjusted from 1.3 V to 16 V using two external resistors. Fixed or adjustable operation is automatically selected via the $\mathrm{V}_{\mathrm{SET}}$ input. The low quiescent current makes these devices especially suitable for battery powered systems. The input voltage range is 2 V to 16.5 V , and an output current up to 100 mA is provided. Current limiting may be set using a single external resistor. For additional safety, an internal thermal shutdown circuit monitors the internal die temperature.
The ADM666A features additional low battery monitoring circuitry to detect for low battery voltages.
The ADM663A/ADM666A are pin compatible enhancements for the ADM663/ADM666. Improvements include an additional 3.3 V output range, higher output current, and operation with a small output capacitor.
The ADM663A/ADM666A are available in an 8-pin DIP and narrow surface mount (SOIC) packages.

[^116]This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

| Parameter | Min | Typ | Max | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Input Voltage, $\mathrm{V}_{\text {IN }}$ | 2.0 |  | 16.5 | V |  |
| Quiescent Current, $\mathrm{I}_{\mathrm{Q}}$ |  | 6 | 9 | $\mu \mathrm{A}$ | No Load, $\mathrm{V}_{\text {IN }}=+16.5 \mathrm{~V}$ |
| Output Voltage, $\mathrm{V}_{\text {OUT (2) }}(+5 \mathrm{~V}$ Mode) | 4.75 | 5.0 | 5.25 | V | $\mathrm{V}_{\text {SET }}=\mathrm{GND}$ |
| Output Voltage, $\mathrm{V}_{\text {OUT }(2)}(+3.3 \mathrm{~V}$ Mode) | 3.135 | 3.3 | 3.465 | V | $\mathrm{V}_{\text {SET }}=\mathrm{V}_{\text {IN }}$ |
| Dropout Voltage, $\mathrm{V}_{\text {Do }}$ |  | 0.75 | 0.9 | V | $\mathrm{I}_{\text {OUT }}=40 \mathrm{~mA}, \mathrm{~V}_{\text {OUT }}=+14.5 \mathrm{~V}$ |
| Dropout Voltage, $\mathrm{V}_{\mathrm{Do}}$ |  | 1.0 | 1.2 | V | $\mathrm{I}_{\text {OUT }}=100 \mathrm{~mA}, \mathrm{~V}_{\text {OUT }}=+14.5 \mathrm{~V}$ |
| Line Regulation ( $\Delta \mathrm{V}_{\text {OUT }(2)} / \Delta \mathrm{V}_{\text {IN }}$ ) |  | 0.03 | 0.35 | \%/V | $+2 \mathrm{~V} \leq \mathrm{V}_{\text {IN }} \leq+15 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=\mathrm{V}_{\text {REF }}$ |
| Load Regulation |  |  |  |  | $\mathrm{V}_{\text {IN }}=\left(\mathrm{V}_{\text {OUT }}+3 \mathrm{~V}\right), 1 \mathrm{~mA} \leq \mathrm{I}_{\text {OUT (2) }} \leq 100 \mathrm{~mA}$ |
| $\Delta \mathrm{V}_{\text {OUT (2) }} ;\left(\Delta \mathrm{V}_{\text {OUT }(2)} / \Delta \mathrm{I}_{\text {OUT }(2)}\right)$ |  | 0.3 | 1.0 | $\Omega$ | $\mathrm{V}_{\text {SET }}=\mathrm{GND}$ (Fixed + 5 V Output) |
|  |  | 0.15 | 0.35 | $\Omega$ | $\mathrm{V}_{\text {SET }}=\mathrm{V}_{\text {IN }}$ (Fixed +3.3 V Output) |
|  |  | 0.15 | 0.30 | $\Omega$ | $\mathrm{V}_{\text {SET }}=$ Resistive Divider (Adjustable Output) |
| $\Delta \mathrm{V}_{\text {OUTI }} ;\left(\Delta \mathrm{V}_{\text {OUT1 }} / \Delta \mathrm{I}_{\text {OUTI }}\right)$ |  | 0.25 | 1.2 | $\Omega$ | ADM663A, $50 \mu \mathrm{~A} \leq \mathrm{I}_{\text {OUT }} \leq 10 \mathrm{~mA}$ |
| Reference Voltage, $\mathrm{V}_{\text {SET }}$ | 1.27 |  | 1.33 | V | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\text {OUT }}=\mathrm{V}_{\text {SET }}$ |
| Reference Tempco ( $\Delta \mathrm{V}_{\text {SET }} / \Delta \mathrm{T}$ ) |  | $\pm 100$ |  | ppm $/{ }^{\circ} \mathrm{C}$ |  |
| $\mathrm{V}_{\text {SET }}$ Internal Threshold |  |  |  |  |  |
| $\mathrm{V}_{\text {F/A }}$ Low |  | 50 |  | mV | $\mathrm{V}_{\text {SET }}<\mathrm{V}_{\mathrm{F} / \mathrm{A}}$ Low for +5 V Output |
| $\mathrm{V}_{\mathrm{F} / \mathrm{A}}$ High |  | $\mathrm{V}_{\text {IN }}-$ |  | mV | $\mathrm{V}_{\mathrm{SET}}>\mathrm{V}_{\mathrm{F} / \mathrm{A}}$ High for +3.3 V Output |
| $\mathrm{V}_{\text {SET }}$ Input Current, $\mathrm{I}_{\text {SET }}$ |  | $\pm 0.01$ | $\pm 10$ | nA |  |
| Shutdown Input Voltage, $\mathrm{V}_{\text {SHDN }}$ | 1.4 |  |  | V | $\mathrm{V}_{\text {SHDN }}$ High $=$ Output Off |
|  |  |  | 0.3 | V | $\mathrm{V}_{\text {SHDN }}$ Low $=$ Output On |
| Shutdown Input Current, $\mathrm{I}_{\text {SHDN }}$ |  | $\pm 0.01$ | $\pm 10$ | nA |  |
| SENSE Input Threshold, V OUt - V ${ }_{\text {SENSE }}$ |  | 0.5 |  | V | Current Limit Threshold |
| SENSE Input Resistance, $\mathrm{R}_{\text {SENSE }}$ |  | 3 |  | $\mathrm{M} \Omega$ |  |
| Input-Output Saturation Resistance, $\mathrm{R}_{\mathrm{SAT}}$ ADM663A, Vout1 |  | 200 | 400 | $\Omega$ | $\mathrm{V}_{\text {IN }}=+2 \mathrm{~V}, \mathrm{I}_{\text {Out }}=1 \mathrm{~mA}$ |
|  |  | 20 | 40 | $\Omega$ | $\mathrm{V}_{\text {IN }}=+9 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=10 \mathrm{~mA}$ |
|  |  | 20 | 30 | $\Omega$ | $\mathrm{V}_{\text {IN }}=+15 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=10 \mathrm{~mA}$ |
| Output Current, $\mathrm{I}_{\text {OUT(2) }}$ | 100 |  |  | mA | $+3 \mathrm{~V} \leq \mathrm{V}_{\text {IN }} \leq+16.5 \mathrm{~V}, \mathrm{~V}_{\text {IN }}-\mathrm{V}_{\text {OUT }}=+1.5 \mathrm{~V}$ |
| Minimum Load Current, $\mathrm{I}_{\text {L (MIN) }}$ |  |  | 1.0 | $\mu \mathrm{A}$ |  |
| LBI Input Threshold |  |  |  |  |  |
| Low Going | 1.1 | 1.26 |  | V | ADM666A |
| High Going |  | 1.29 | 1.42 | V | ADM666A |
| Hysteresis |  | 30 |  | mV | ADM666A |
| LBI Input Current, $\mathrm{I}_{\text {LBI }}$ |  | $\pm 0.01$ | $\pm 10$ | nA | ADM666A |
| LBO Output Saturation Resistance, $\mathrm{R}_{\text {SAT }}$ |  | 20 | 30 | $\Omega$ | ADM666A, $\mathrm{I}_{\text {SAT }}=2 \mathrm{~mA}$ |
| LBO Output Leakage Current |  | 0.2 |  | nA | ADM666A, LBI $=1.4 \mathrm{~V}$ |
| $\mathrm{V}_{\text {TC }}$ Open Circuit Voltage, $\mathrm{V}_{\text {TC }}$ |  | 0.9 |  | V | ADM663A |
| $\mathrm{V}_{\mathrm{TC}}$ Sink Current, $\mathrm{I}_{\text {TC }}$ |  | 8.0 | 2.0 | mA | ADM663A |
| $\mathrm{V}_{\text {TC }}$ Temperature Coefficient |  | +2.5 |  | $\mathrm{mV} /{ }^{\circ} \mathrm{C}$ | ADM663A |

Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS ${ }^{\star}$

( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)
Input Voltage, $\mathrm{V}_{\text {IN }}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . +18 V
Terminal Voltage
(ADM663A) Pins 1, 3, 5, 6, 7

(ADM666A) Pins 1, 2, 3, 5, 6
$(\mathrm{GND}-0.3 \mathrm{~V})$ to $\left(\mathrm{V}_{\mathrm{IN}}+0.3 \mathrm{~V}\right)$
(ADM663A) Pin $2 \ldots \ldots . .(G N D-0.3 \mathrm{~V})$ to $\left(\mathrm{V}_{\text {OUT } 1}+0.3 \mathrm{~V}\right)$
(ADM666A) Pin $7 \ldots \ldots . \ldots$. . . . . (GND-0.3 V) to +16.5 V
Output Source Current


Power Dissipation, R-8 . . . . . . . . . . . . . . . . . . . . . . . 570 mW
(Derate $6 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+30^{\circ} \mathrm{C}$ )
$\theta_{\mathrm{JA}}$, Thermal Impedance . . . . . . . . . . . . . . . . . . . . . $170^{\circ} \mathrm{C} / \mathrm{W}$
Operating Temperature Range
Industrial (A Version)
. $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 sec ) . . . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Vapor Phase ( 60 sec ) . . . . . . . . . . . . . . . . . . . . . . . . $+215^{\circ} \mathrm{C}$
Infrared (15 sec) . . . . . . . . . . . . . . . . . . . . . . . . . . . . $+220^{\circ} \mathrm{C}$
ESD Rating . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $>5000$ V
*This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

PIN FUNCTION DESCRIPTION

| Mnemonic | Function |
| :---: | :---: |
| $\mathrm{V}_{\text {OUT(1) (2) }}$ | Voltage Regulator Output(s). |
| $\mathrm{V}_{\text {IN }}$ | Voltage Regulator Input. |
| SENSE | Current Limit Sense Input. (Referenced to $\mathrm{V}_{\text {OUT(2). }}$ ) If not used, it should be connected to $\mathrm{V}_{\text {OUT(2). }}$ |
| GND | Ground Pin. Must be connected to 0 V . |
| LBI | Low Battery Detect Input. Compared with 1.3 V. |
| LBO | Low Battery Detect Output. Open Drain Output. |
| SHDN | Digital Input. May be used to disable the device so that the power consumption is minimized. |
| $\mathrm{V}_{\text {SET }}$ | Voltage Setting Input. Connect to GND for +5 V output, to $\mathrm{V}_{\text {IN }}$ for +3.3 V output or connect to external resistive divider for adjustable output. |
| $\mathrm{V}_{\mathrm{TC}}$ | Temperature-Proportional Voltage for negative TC Output. |

## PIN CONFIGURATIONS DIP \& SOIC



## DIP \& SOIC



ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Option |
| :--- | :--- | :--- |
| ADM663AAN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| ADM663AAR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | R-8 |
| ADM666AAN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| ADM666AAR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | R-8 |

[^117]
## TERMINOLOGY

Dropout Voltage: The input/output voltage differential at which the regulator no longer maintains regulation against further reductions in input voltage. It is measured when the output decreases 100 mV from its nominal value. The nominal value is the measured value with $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\text {OUT }}+2 \mathrm{~V}$.
Line Regulation: The change in output voltage as a result of a change in the input voltage. It is specified as a percentage change in output voltage for an input voltage change.

$$
\text { Line Reg }=\frac{\frac{\Delta V_{\text {OUT }}}{V_{\text {OUT }}}(100)}{\Delta V_{I N}}
$$

Load Regulation: The change in output voltage for a change in output current.

$$
\operatorname{Load} \operatorname{Reg}(\Omega)=\frac{\Delta V_{O U T}}{\Delta I_{O U T}}
$$

Quiescent Current: The input bias current which flows when the regulator output is unloaded or when the regulator is in shutdown.
Sense Input Threshold: Current limit sense voltage. This is the voltage (referenced to $\mathrm{V}_{\text {OUT(2) }}$ ) at which current limiting occurs.
Input-Output Saturation Resistance (ADM663A): This is a measure of the internal MOS transistor effective resistance in series with $\mathrm{V}_{\text {OUT1 }}$. The minimum input-output voltage differential at low currents may be calculated by multiplying the load cur- " rent by the saturation resistance.

Thermal Limiting: This feature monitors the internal die temperature and disables the output when an internal temperature of $125^{\circ} \mathrm{C}$ is reached.

Maximum Power Dissipation: The maximum total device dissipation for which the regulator will continue to operate within specifications.

## GENERAL INFORMATION

The ADM663A/ADM666A contains a micropower bandgap reference voltage source; an error amplifier, A1; three comparators, C1, C2, C3, and a series pass output transistor. A P-channel FET and an NPN transistor are used on the ADM663A while the ADM666A uses an NPN output transistor.

## CIRCUIT DESCRIPTION

The internal bandgap reference is trimmed to $1.3 \mathrm{~V} \pm 30 \mathrm{mV}$. This is used as a reference input to the error amplifier A1. The feedback signal from the regulator output is supplied to the other input by an on-chip voltage divider or by two external resistors. When $\mathrm{V}_{\mathrm{SET}}$ is at ground, the internal divider tap between R1 and R2, provides the error amplifier's feedback signal giving $\mathrm{a}+5 \mathrm{~V}$ output. When $\mathrm{V}_{\text {SET }}$ is at $\mathrm{V}_{\text {IN }}$, the internal divider tap between R2 and R3 provides the error amplifier's feedback signal giving $\mathrm{a}+3.3 \mathrm{~V}$ output. When $\mathrm{V}_{\mathrm{SET}}$ is at more than 50 mV above ground and less than 50 mV below $\mathrm{V}_{\text {IN }}$, the error amplifier's input is switched directly to the $\mathrm{V}_{\mathrm{SET}}$ pin, and external resistors are used to set the output voltage. The external resistors are selected so that the desired output voltage gives 1.3 V at $V_{\text {SET }}$.

Comparator C 1 monitors the output current via the SENSE input. This input, referenced to $\mathrm{V}_{\text {OUT(2) }}$, monitors the voltage drop across a load sense resistor. If the voltage drop exceeds 0.5 V , then the error amplifier A 1 is disabled and the output current is limited.
The ADM663A has an additional amplifier, A2, which provides a temperature proportional output, $\mathrm{V}_{\mathrm{TC}}$. If this is summed into the inverting input of the error amplifier, a negative temperature coefficient results at the output. This is useful when powering liquid crystal displays over wide temperature ranges.

The ADM666A has an additional comparator, C 4 , that compares the voltage on the low battery input, LBI, pin to the internal +1.3 V reference. The output from the comparator drives an open drain FET connected to the low battery output pin, LBO. The low battery threshold may be set using a suitable voltage divider connected to LBI. When the voltage on LBI falls below 1.3 V , the open drain output LBO is pulled low.


Figure 1. ADM663A Functional Block Diagram

Both the ADM663A and the ADM666A contain a shutdown (SHDN) input that can be used to disable the error amplifier and hence the voltage output. The power consumption in shutdown reduces to less than $9 \mu \mathrm{~A}$.


## Figure 2. ADM666A Functional Block Diagram

## Circuit Configurations

For a fixed +5 V output the $\mathrm{V}_{\text {SET }}$ input is grounded and no external resistors are necessary. This basic configuration is shown in Figure 3. For a fixed +3.3 V output, the $\mathrm{V}_{\mathrm{SET}}$ input is connected to $\mathrm{V}_{\mathrm{IN}}$ as shown in Figure 4. Current limiting is not being utilized so the SENSE input is connected to $\mathrm{V}_{\text {OUT(2) }}$.


Figure 3. A Fixed +5 V Output


Figure 4. A Fixed $+3.3 \vee$ Output

## Output Voltage Setting

If $\mathrm{V}_{\text {SET }}$ is not connected to GND or to $\mathrm{V}_{\text {IN }}$, the output voltage is set according to the following equation:

$$
V_{O U T}=V_{S E T} \times \frac{(R 1+R 2)}{R 1}
$$

where $\mathrm{V}_{\mathrm{SET}}=1.30 \mathrm{~V}$.

## ADM663A/ADM666A

The resistor values may be selected by first choosing a value for R1 and then selecting R2 according to the following equation:

$$
R 2=R 1 \times\left(\frac{V_{\text {OUT }}}{1.30}-1\right)
$$

The input leakage current on $\mathrm{V}_{\text {SET }}$ is 10 nA maximum. This allows large resistor values to be chosen for R1 and R2 with little degradation in accuracy. For example, a $1 \mathrm{M} \Omega$ resistor may be selected for R1, and then R2 may be calculated accordingly. The tolerance on $V_{\text {SET }}$ is guaranteed at less than $\pm 30 \mathrm{mV}$ so in most applications, fixed resistors will be suitable.


Figure 5. Adjustable Output

Table I. Output Voltage Selection

| $\mathbf{V}_{\text {SET }}$ | $\mathbf{V}_{\text {OUT }}$ |
| :--- | :--- |
| GND | +5 V |
| $\mathrm{~V}_{\text {IN }}$ | +3 V |
| R1/R2 | ADJ |

## Current Limiting

Current limiting may be achieved by using an external current sense resistor in series with $\mathrm{V}_{\mathrm{OUT}(2)}$. When the voltage across the sense resistor exceeds the internal 0.5 V threshold, current limiting is activated. The sense resistor is therefore chosen such that the voltage across it will be 0.5 V when the desired current limit is reached.

$$
R_{C L}=\frac{0.5}{I_{C L}}
$$

where $\mathrm{R}_{\mathrm{CL}}$ is the current sense resistor, $\mathrm{I}_{\mathrm{CL}}$ is the maximum current limit.

The value chosen for $\mathrm{R}_{\mathrm{CL}}$ should also ensure that the current is limited to less than the 100 mA absolute maximum rating and also that the power dissipation will also be within the package maximum ratings.
If current limiting is employed, there will be an additional voltage drop across the sense resistor that must be considered when determining the regulators dropout voltage.

If current limiting is not used, the SENSE input should be connected to $\mathrm{V}_{\text {OUT(2) }}$.

## Shutdown Input (SHDN)

The SHDN input allows the regulator to be turned off with a logic level signal. This will disable the output and reduce
the current drain to a low quiescent ( $9 \mu \mathrm{~A}$ maximum) current. This is very useful for low power applications. The SHDN input should be driven with a CMOS logic level signal since the input threshold is 0.3 V . In TTL systems, an open collector driver with a pull-up resistor may be used.
If the shutdown function is not being used, then it should be connected to GND.

## Low Supply or Low Battery Detection

The ADM666A contains on-chip circuitry for low power supply or battery detection. If the voltage on the LBI pin falls below the internal 1.3 V reference, then the open drain output LBO will go low. The low threshold voltage may be set to any voltage above 1.3 V by appropriate resistor divider selection.

$$
R 3=R 4\left(\frac{V_{B A T T}}{1.3 V}-1\right)
$$

where $R 3$ and $R 4$ are the resistive divider resistors and $V_{\text {BATT }}$ is the desired low voltage threshold.

Since the LBI input leakage current is less than 10 nA , large values may be selected for R3 and R4 in order to minimize loading. For example, a 6 V low threshold may be set using $10 \mathrm{M} \Omega$ for R3 and $2.7 \mathrm{M} \Omega$ for R4.


Figure 6. ADM666A Adjustable Output with Low Battery Detection

## High Current Operation

The ADM663A contains an additional output, $\mathrm{V}_{\text {OUT1 }}$, suitable for directly driving the base of an external NPN transistor. Figure 7 shows a configuration which can be used to provide +5 V with boosted current drive. A $1 \Omega$ current sensing resistor limits the current at 0.5 A .


Figure 7. ADM663A Boosted Output Current (0.5 A)

## Temperature Proportional Output

The ADM663A contains a $\mathrm{V}_{\mathrm{TC}}$ output with a positive temperature coefficient of $+2.5 \mathrm{mV} /{ }^{\circ} \mathrm{C}$. This may be connected to the summing junction of the error amplifier ( $\mathrm{V}_{\mathrm{SET}}$ ) through a resistor resulting in a negative temperature coefficient at the output of the regulator. This is especially useful in multiplexed LCD displays to compensate for the inherent negative temperature coefficient of the LCD threshold. At $+25^{\circ} \mathrm{C}$ the voltage at the VTC output is typically 0.9 V . The equations for setting both the output voltage and the tempco are given below. If this function is not being used, then $\mathrm{V}_{\mathrm{TC}}$ should be left unconnected.

$$
\begin{gathered}
V_{O U T}=V_{S E T}\left(1+\frac{R 2}{R 1}\right)+\frac{R 2}{R 3}\left(V_{S E T}-V_{T C}\right) \\
T C V_{O U T}=\frac{-R 2}{R 3}\left(T C V_{T C}\right)
\end{gathered}
$$

where $\mathrm{V}_{\mathrm{SET}}=+1.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{TC}}=+0.9 \mathrm{~V}, \mathrm{TCV}_{\mathrm{TC}}=+2.5 \mathrm{mV} /{ }^{\circ} \mathrm{C}$


Figure 8. ADM663A Temperature Proportional Output

## APPLICATION HINTS

## Input-Output (Dropout Voltage)

A regulator's minimum input-output differential or dropout voltage determines the lowest input voltage for a particular output voltage. The ADM663A/ADM666A dropout voltage is 1 V at its rated output current. For example when used as a fixed +5 V regulator, the minimum input voltage is +6 V . At lower output currents ( $\mathrm{I}_{\text {OUT }}<10 \mathrm{~mA}$ ) on the ADM663A, $\mathrm{V}_{\text {OUTI }}$ may be used as the output driver in order to achieve lower dropout voltages. In this case the dropout voitage depends on the voltage drop across the internal FET transistor. This may be calculated by multiplying the FET's saturation resistance by the output current, for example with $\mathrm{V}_{\mathrm{IN}}=9 \mathrm{~V}, \mathrm{R}_{\mathrm{SAT}}=20 \Omega$. Therefore, the dropout voltage for 5 mA is 100 mV . As the current limit circuitry is referenced to $\mathrm{V}_{\text {OUT2 }}, \mathrm{V}_{\text {OUT2 }}$ should be connected to $\mathrm{V}_{\text {OUT1 }}$. For high current operation $\mathrm{V}_{\text {OUT2 }}$ should be used alone and $V_{\text {OUT1 }}$ left unconnected.


Figure 9. Low Current, Low Dropout Configuration

## Thermal Considerations

The ADM663A/ADM666A can supply up to 100 mA load current and can operate with input voltages up to 16.5 V , but the package power dissipation and hence the die temperature must
be kept within the maximum limits. The package power dissipation is calculated from the product of the voltage differential across the regulator times the current being supplied to the load. The power dissipation must be kept within the maximum limits given in the Absolute Maximum Ratings section.

$$
P_{D}=\left(V_{I N}-V_{O U T}\right)\left(I_{L}\right)
$$

The die temperature is dependent on both the ambient temperature and on the power being dissipated by the device. The ADM663A/ADM666A contains an internal thermal limiting circuit which will shut down the regulator if the internal die temperature exceeds $125^{\circ} \mathrm{C}$. Therefore, care must be taken to ensure that, under normal operating conditions, the die temperature is kept below the thermal limit.

$$
T_{y}=T_{A}+P_{D}\left(\theta_{y A}\right)
$$

This may be expressed in terms of power dissipation as follows:

$$
P_{D}=\left(T_{y}-T_{A}\right) /\left(\theta_{\mathscr{Y}}\right)
$$

where:
$T_{f}=$ Die Junction Temperature $\left({ }^{\circ} \mathrm{C}\right)$
$T_{A}=$ Ambient Temperature $\left({ }^{\circ} \mathrm{C}\right)$
$P_{D}=$ Power Dissipation (W)
$\theta_{\nrightarrow A}=$ Junction to Ambient Thermal Resistance $\left({ }^{\circ} \mathrm{C} / \mathrm{W}\right)$
If the device is being operated at the maximum permitted ambient temperature of $85^{\circ} \mathrm{C}$ the maximum power dissipation permitted is:

$$
\begin{aligned}
P_{D}(\max )= & \left(T_{y}(\max )-T_{A}\right) /\left(\theta_{y A}\right) \\
P_{D}(\max ) & =(125-85) /\left(\theta_{\mathrm{JA}}\right) \\
& =40 / \theta_{y A}
\end{aligned}
$$

$\theta_{9 A}=120^{\circ} \mathrm{C} / \mathrm{W}$ for the 8 -pin DIP (N-8) package
$\theta_{y A}=170^{\circ} \mathrm{C} / \mathrm{W}$ for the 8 -pin SOIC (R-8) package
Therefore, for a maximum ambient temperature of $85^{\circ} \mathrm{C}$

$$
\begin{aligned}
& P_{D}(\max )=333 m W \text { for } N-8 \\
& P_{D}(\max )=235 m W \text { for } R-8
\end{aligned}
$$

At lower ambient temperatures the maximum permitted power dissipation increases accordingly up to the maximum limits specified in the absolute maximum specifications.
The thermal impedance $\left(\theta_{\mathrm{JA}}\right)$ figures given are measured in still air conditions and are reduced considerably where fan assisted cooling is employed. Other techniques for reducing the thermal impedance include large contact pads on the printed circuit board and wide traces. The copper will act as a heat exchanger thereby reducing the effective thermal impedance.

## Bypass Capacitors

The high frequency performance of the ADM663A/ADM666A may be improved by decoupling the ouput using a filter capacitor. A capacitor of $0.1 \mu \mathrm{~F}$ is suitable.
An input capacitor helps reduce noise, improves dynamic performance and reduces the input $\mathrm{dV} / \mathrm{dt}$ at the regulator input. A suitable input capacitor is $0.1 \mu \mathrm{~F}$ or greater. +10V Precision Voltage Reference

## REFO1

## FEATURES

- 10 Volt Output .................................. . $\pm 0.3 \%$ Max
- Adjustment Range ................................. $\pm 3 \%$ Min
- Excellent Temperature Stability ....... 8.5ppm/ ${ }^{\circ} \mathrm{C}$ Max
- Low Noise $30 \mu V_{\text {p-p }}$ Max
- Low Supply Current 1.4mA Max
- Wide Input Voltage Range 12 V to 40 V
- High Load-Driving Capability 20 mA
- No External Components
- Short-Circuit Proof
- MIL-STD-883 Screening Available
- Available in Die Form


## ORDERING INFORMATION ${ }^{\dagger}$

| $\begin{gathered} T_{\hat{A}}=25^{\circ} \mathrm{C} \\ \Delta \mathrm{~V}_{o b} \mathrm{MAXX} \\ (\mathrm{mV}) \end{gathered}$ | PACKAGE |  |  |  | OPERATING MPERATURE RANGE |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | TO-99 | CERDIP <br> 8-PIN | $\begin{aligned} & \text { PLASTIC } \\ & \text { Q-PIN } \end{aligned}$ |  |  |
| $\pm 30$ | REF01AJ* | REF01AZ* | - | - | MIL |
| $\pm 30$ | REF01EJ | REF01EZ | - | - | COM |
| $\pm 50$ | REF01J* | REF012* | - | REF01RC/883 | MIL |
| $\pm 50$ | REF01HJ | REF01HZ | REF01HP | - | COM |
| $\pm 100$ | REF01C | REF01CZ | - - | - | COM |
| $\pm 100$ | - | - | REF01CP | - | XIND |
| $\pm 100$ | - | - | REF01CS $\dagger \dagger$ | : - | XIND |

* For devices processed in total compliance to MIL-STD-883, add /883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.
ti For availability and burn-in information on SO and PLCC packages, contact your local sales office.


## GENERAL DESCRIPTION

The REF-01 precision voltage reference provides a stable
+10 V output which can be adjusted over a $\pm 3 \%$ range with minimal effect on temperature stability. Single-supply operation over an input voltage range of 12 V to 40 V , low current drain of 1 mA , and excellent temperature stability are achieved with an improved bandgap design. Low cost, low noise, and low power make the REF-01 an excellent choice whenever a stable voltage reference is required. Applications include D/A and A/D converters, portable instrumentation, and digital voltmeters. Full military temperature range devices with screening to MIL-STD-883 are available. For guaranteed long-term drift see the REF-10 data sheet.

## PIN CONNECTIONS


(J-Suffix)




EPOXY MINI-DIP
(P-Suffix)
8-PIN HERMETIC DIP (Z-Suffix)
8-PIN SO
(S-Suffix)

REF-01RC/883
LCC (RC-Suffix)

## SIMPLIFIED SCHEMATIC



This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.


Junction Temperature (T) ............................. $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ Lead Temperature (Soldering, 60 sec ) ............................ $300^{\circ} \mathrm{C}$

| PACKAGE TYPE | $\theta_{14}$ (NOTE 2) | $\theta_{16}$ | UNITS |
| :---: | :---: | :---: | :---: |
| TO-99 (J) | 170 | 24 | ${ }^{\circ} \mathrm{C} / \mathrm{N}$ |
| 8-Pin Hermetic DIP (Z) | 162 | 26 | ${ }^{\circ} \mathrm{C} / \mathrm{N}$ |
| 8-Pin Plastic DIP (P) | 110 | 50 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 20-Contact LCC (RC) | 120 | 40 | ${ }^{\circ} \mathrm{C} / \mathrm{N}$ |
| 8 -Pin SO (S) | 160 | 44 | ${ }^{\circ} \mathrm{C}$ W |
| 20-Contact PLCC (PC) | 80 | 39 | ${ }^{\circ} \mathrm{CN}$ |

## NOTES:

1. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
2. $\Theta_{I A}$ is specified for worst case mounting conditions, i.e., $\Theta_{I A}$ is specified for device in socket for TO, CerDIP, P-DIP, and LCC packages; $\boldsymbol{\theta}_{\mid A}$ is specified for device soldered to printed circuit board for SO and PLCC packages.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{IN}}=+15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.

|  |  |  | REF-01A/E |  |  | REF-01/H |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | max | MIN | TYP | Max | UNITS |
| Output Voltage | $V_{0}$ | $\mathrm{I}_{\mathrm{L}}=0$ | 9.97 | 10.00 | 10.03 | 9.95 | 10.00 | 10.05 | V |
| Output Adjustment Range | $\Delta V_{\text {trim }}$ | $R_{p}=10 \mathrm{k} \Omega$ | $\pm 3.0$ | $\pm 3.3$ | - | $\pm 3.0$ | $\pm 3.3$ | - | \% |
| Output Voltage Noise | $e_{n p-p}$ | 0.1 Hz to 10 Hz (Note 6) | - | 20 | 30 | - | 20 | 30 | $\mu \mathrm{V}_{\mathrm{p}-\mathrm{p}}$ |
| Line Regulation (Note 4) |  | $\mathrm{V}_{\mathbf{I N}}=13 \mathrm{~V}$ to 33 V | - | 0.006 | 0.010 | - | 0.006 | 0.010 | \%/V |
| Load Regulation (Note 4) |  | $\mathrm{I}_{\mathrm{L}}=0$ to 10 mA | - | 0.005 | 0.008 | - | 0.006 | 0.010 | \%/mA |
| Turn-on Settling Time | $t_{0}$ | To $\pm 0.1 \%$ of final value | - | 5 | - | - | 5 | - | $\mu \mathrm{s}$ |
| Quiescent Supply Current | $\mathrm{I}_{\text {SY }}$ | No Load | - | 1.0 | 1.4 | - | 1.0 | 1.4 | mA |
| Load Current | $\mathrm{I}_{\mathrm{L}}$ |  | 10 | 21 | - | 10 | 21 | - | mA |
| Sink Current | $\mathrm{I}_{5}$ | (Note 7) | -0.3 | -0.5 | - | -0.3 | -0.5 | - | mA |
| Short-Circuit Current | $\mathrm{I}_{\mathrm{Sc}}$ | $\mathrm{V}_{\mathrm{O}}=0$ | - | 30 | - | - | 30 | - | mA |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{IN}}=+15 \mathrm{~V},-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ for REF-01 A/E, and $0^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+70^{\circ} \mathrm{C}$ for REF- 01 H and $\mathrm{I}_{\mathrm{L}}=0 \mathrm{~mA}$, unless otherwise noted.

|  |  |  | REF-01A/E |  |  | REF-01/H |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | MIN | TYP | MAX | UNIT8 |
| Ouput Voltage Change with Temperature (Notes 1, 2) | $\Delta V_{\text {OT }}$ | $\begin{aligned} & 0^{\circ} \mathrm{C} \leq T_{A} \leq+70^{\circ} \mathrm{C} \\ & -55^{\circ} \mathrm{C} \leq T_{A} \leq+125^{\circ} \mathrm{C} \end{aligned}$ | - | $\begin{aligned} & 0.02 \\ & 0.06 \end{aligned}$ | $\begin{aligned} & 0.06 \\ & 0.15 \end{aligned}$ | - | $\begin{aligned} & 0.07 \\ & 0.18 \end{aligned}$ | $\begin{aligned} & 0.17 \\ & 0.45 \end{aligned}$ | \% |
| Output Voltage <br> Temperature Coefficient | TCV | (Note 3) | - | 3.0 | 8.5 | - | 10.0 | 25.0 | ppm $/{ }^{\circ} \mathrm{C}$ |
| Change in $\mathrm{V}_{\mathbf{O}}$ Temperature Coefficient with Output Adjustment |  | $R_{p}=10 \mathrm{k} \Omega$ | - | 0.7 | - | - | 0.7 | - | ppm/\% |
| Line Regulation $\left(V_{I N}=13 \mathrm{~V}\right. \text { to 33V)(Note 4) }$ |  | $\begin{aligned} & 0^{\circ} \mathrm{C} \leq T_{A} \leq+70^{\circ} \mathrm{C} \\ & -55^{\circ} \mathrm{C} \leq T_{A} \leq+125^{\circ} \mathrm{C} \end{aligned}$ | - | $\begin{aligned} & 0.007 \\ & 0.009 \end{aligned}$ | $\begin{aligned} & 0.012 \\ & 0.015 \end{aligned}$ | - | $\begin{aligned} & 0.007 \\ & 0.009 \end{aligned}$ | $\begin{aligned} & 0.012 \\ & 0.015 \end{aligned}$ | \%/V |
| Load Regulation ( $\mathrm{L}_{\mathrm{L}}=0$ to 8 mA ) (Note 4) |  | $\begin{aligned} & 0^{\circ} \mathrm{C} \leq T_{A} \leq+70^{\circ} \mathrm{C} \\ & -55^{\circ} \mathrm{C} \leq T_{A} \leq+125^{\circ} \mathrm{C} \end{aligned}$ | - | $\begin{aligned} & 0.006 \\ & 0.007 \end{aligned}$ | $\begin{aligned} & 0.010 \\ & 0.012 \end{aligned}$ | - | $\begin{aligned} & 0.007 \\ & 0.009 \end{aligned}$ | $\begin{aligned} & 0.012 \\ & 0.015 \end{aligned}$ | \%/mA |

## NOTE8:

1. $\Delta \mathbf{V}_{\mathrm{OT}}$ is defined as the absolute difference between the maximum output voltage and the minimum output voltage over the specified temperature range expressed as a percentage of 10 V :

$$
\Delta V_{O T}=\left|\frac{V_{\text {MAX }}-V_{\text {MIN }}}{10 V}\right| \times 100
$$

$$
\mathrm{TCV}_{\mathrm{O}}\left(0^{\circ} \text { to }+70^{\circ} \mathrm{C}\right)=\frac{\Delta \mathrm{V}_{\mathrm{OT}}\left(0^{\circ} \text { to }+70^{\circ} \mathrm{C}\right)}{70^{\circ} \mathrm{C}}
$$

and $\operatorname{TCV}_{\mathrm{O}}\left(-55^{\circ}\right.$ to $\left.+125^{\circ} \mathrm{C}\right)=\frac{\Delta \mathrm{V}_{\mathrm{OT}}\left(-55^{\circ} \text { to }+125^{\circ} \mathrm{C}\right)}{180^{\circ} \mathrm{C}}$
2. $\Delta \mathrm{V}_{\mathrm{OT}}$ specification applies trimmed to +10.000 V or untrimmed.
4. Line and Load Regulation specifications include the effect of self heating.
3. $T C V_{O}$ is defined as $\Delta V_{O T}$ divided by the temperature range, i.e.,
5. Guaranteed by design.
6. Sample tested.
7. During sink current test the device meets the output voltage specified.

## REFO1

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{IN}}=+15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | MIN | $\begin{gathered} \text { REF-01C } \\ \text { TYP } \end{gathered}$ | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output Voltage | $V_{0}$ | $\mathrm{I}_{\mathrm{L}}=0 \mathrm{~mA}$ | 9.90 | 10.00 | 10.10 | V |
| Output Adjustment Range | $\Delta V_{\text {trim }}$ | $R_{p}=10 \mathrm{k} \Omega$ | $\pm 2.7$ | $\pm 3.3$ | - | \% |
| Output Voltage Noise | $e_{\text {np-p }}$ | 0.1 Hz to 10 Hz (Note 6) | - | 25 | 35 | $\mu \mathrm{V}_{\mathrm{p}-\mathrm{p}}$ |
| Line Regulation (Note 4) |  | $V_{I N}=13 \mathrm{~V}$ to 30 V | - | 0.009 | 0.015 | \%/V |
| Load Regulation (Note 4) |  | $\mathrm{I}_{\mathrm{L}}=0$ to 8 mA | - | 0.006 | 0.015 | \%/mA |
| Turn-on Settling Time | ${ }^{\text {O }}$ ON | To $\pm 0.1 \%$ of final value | - | 5 | - | $\mu \mathrm{S}$ |
| Quiescent Supply Current | $\mathrm{I}_{\text {SY }}$ | No Load | - | 1.0 | 1.6 | mA |
| Load Current | $I_{L}$ |  | 8 | 21 | - | mA |
| Sink Current | $I_{S}$ | (Note 7 ) | -0.3 | -0.5 | - | mA |
| Short-Circuit Current | $I_{\text {SC }}$ | $\mathrm{V}_{\mathrm{O}}=0$ | - | 30 | - | mA |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{I N}=+15 \mathrm{~V}^{\circ} \mathrm{C} \leq \mathrm{T}_{A} \leq+70^{\circ} \mathrm{C}$ for REF- $01 \mathrm{CJ}, \mathrm{CZ},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{A} \leq+85^{\circ} \mathrm{C}$ for REF-01CP,CS, unless otherwise noted.

| PARAMETER | sYMBOL | CONDITIONS | MIN | REF-01C TYP | Max | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Ouput Voltage Change with Temperature | $\Delta V_{\text {OT }}$ | (Notes 1 and 2) | - | 0.14 | 0.45 | \% |
| Output Voltage Temperature Coefficient | TCV ${ }_{0}$ | (Note 3) | - | 20 | 65 | ppm/ ${ }^{\circ} \mathrm{C}$ |
| Change in $\mathrm{V}_{\mathrm{O}}$ Temperature Coefficient with Output Adjustment |  | $\mathrm{R}_{\mathrm{p}}=10 \mathrm{k} \Omega$ | - | 0.7 | - | ppm/\% |
| Line Regulation (Note 4) |  | $V_{\text {IN }}=13 \mathrm{~V}$ to 30 V | - | 0.011 | 0.018 | \%/v |
| Load Regulation (Note 4) |  | $\mathrm{I}_{\mathrm{L}}=0$ to 5 mA | - | 0.008 | 0.018 | \%/mA |

## NOTE8:

1. $\Delta \mathbf{V}_{\mathbf{O T}}$ is defined as the absolute difference between the maximum output voltage and the minimum output voltage over the specified temperature range expressed as a percentage of 10 V :

$$
\Delta V_{\text {OT }}=\left|\frac{V_{\text {MAX }}-V_{\text {MIN }}}{10 V}\right| \times 100
$$

2. $\Delta \mathrm{V}_{\mathrm{OT}}$ specification applies trimmed to +10.000 V or untrimmed.
3. $T C V_{O}$ is defined as $\Delta V_{O T}$ divided by the temperature range, i.e.,

## OUTPUT ADJUSTMENT



The REF-01 trim terminal can be used to adjust the output voltage over a $10 \mathrm{~V} \pm 300 \mathrm{mV}$ range. This feature allows the system designer to trim system errors by setting the reference to a voltage other than 10V. Of course, the output can

$$
\mathrm{TCV}_{\mathrm{O}}=\frac{\Delta \mathrm{V}_{\mathrm{OT}}}{70^{\circ} \mathrm{C}}
$$

4. Line and Load Regulation specifications include the effect of self heating.
5. Guaranteed by design.
6. Sample tested.
7. During sink current test the device meets the output voltage specified.

## BURN-IN CIRCUIT


also be set to exactly 10.000 V , or to 10.240 V for binary applications.

Adjustment of the output does not significantly affect the temperature performance of the device. The temperature coefficient change is approximately $0.7 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ for 100 mV of output adjustment.

# +5 V Precision Voltage Reference/Temperature Transducer 

## FEATURES

- 5 Volt Output . ................................ $\pm 0.3 \%$ Max
- Temperature Voltage Output . . . . . . . . . ........ . $2.1 \mathrm{mV} /{ }^{\circ} \mathrm{C}$
- Adjustment Range ................................. $\pm$ 3\% Min
- Excellent Temperature Stability ....... 8.5ppm/ ${ }^{\circ} \mathrm{C}$ Max
- Low Noise .................................... . $15 \mu \mathbf{V}_{\text {p-p }}$ Max
- Low Supply Current . . . . . . . . . . . . . . . . . . . . . . . . . 1.4mA Max
- Wide Input Voltage Range ..................... . 7 . to 40V
- High Load-Driving Capability ....................... . 20mA
- No External Components
- Short-Circuit Proof
- MIL-STD-883 Screening Available
- Available in Die Form


## ORDERING INFORMATION ${ }^{\dagger}$

| $\begin{gathered} T_{A}=25^{\circ} \mathrm{C} \\ \mathrm{~V}_{\text {OS }} \mathrm{MAX} \\ (\mathrm{mV}) \end{gathered}$ | PACKAGE |  |  |  | OPERATING TEMPERATURE RANGE |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | TO-99 | CERDIP 8-PIN | PLASTIC 8-PIN | LCC 20-CONTACT |  |
| $\pm 15$ | REF02AJ* | REF02AZ* | - | - | MIL |
| $\pm 15$ | REF02EJ | REF02EZ | - | - | COM |
| $\pm 25$ | REF02J* | REF02Z* | - | REF02RC/883 | MIL |
| $\pm 25$ | REF02HJ | REFO2HZ | REF02HP | - | COM |
| $\pm 50$ | REF02CJ | REF02CZ | - | - | COM |
| $\pm 50$ | - | - | REF02CP | - | XIND |
| $\pm 50$ | - | - | REF02CSt $\dagger$ | - | XIND |
| $\pm 100$ | REF02DJ | REF02DZ | REF02DP | - | COM |

* For devices processed in total compliance to MIL-STD-883, add /883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.
tt For availability and burn-in information on SO and PLCC packages, contact your local sales office.


## SIMPLIFIED SCHEMATIC <br> SIMPLIFIE SCHEMATIC

## GENERAL DESCRIPTION

The REF-02 precision voltage reference provides a stable +5 V output which can be adjusted over a $\pm 6 \%$ range with minimal effect on temperature stability. Single-supply operation over an input voltage range of 7 V to 40 V , low current drain of 1 mA , and excellent temperature stability are achieved with an improved bandgap design. Low cost, low noise, and low power make the REF-02 an excellent choice whenever a stable voltage reference is required. Applications include $D / A$ and $A / D$ converters, portable instrumentation, and digital voltmeters. The versatility of the REF-02 is enhanced by its use as a monolithic temperature transducer. For +10 V references, see the REF-01 and REF-10 data sheets.

## PIN CONNECTIONS



This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.


Junction Temperature ( $\mathrm{T}_{\mathrm{j}}$ ) ............................ $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

| PACKAGE TYPE | $\Theta_{\text {JA }}$ (NOTE 2) | $\boldsymbol{\theta}_{\mathrm{JC}}$ | UNITS |
| :--- | :---: | :---: | :---: |
| TO-99 (J) | 170 | 24 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8 -Pin Hermetic DIP (Z) | 162 | 26 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8 -Pin Plastic DIP (P) | 110 | 50 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $20-$ Contact LCC (RC, TC) | 120 | 40 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8 -Pin SO (S) | 160 | 44 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $20-C o n t a c t ~ P L C C ~(P C) ~$ | 80 | 39 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTES

1. Absolute maximum ratings apply to both DICE and packaged parts, uniess otherwise noted.
2. $\Theta_{j A}$ is specified for worst case mounting conditions, i.e., $\Theta_{j A}$ is specified for device in socket for TO, CerDIP, P-DIP, and LCC packages; $\boldsymbol{\theta}_{j \text { A }}$ is specified for device soldered to printed circuit board for SO and PLCC packages.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{IN}}=+15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | REF-02A/E |  |  | REF-02/H |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Output Voltage | $V_{0}$ | $\mathrm{I}_{\mathrm{L}}=0$ | 4.985 | 5.000 | 5.015 | 4.975 | 5.000 | 5.025 | V |
| Output Adjustment Range | $\Delta V_{\text {trim }}$ | $\mathrm{R}_{\mathrm{p}}=10 \mathrm{k} \Omega$ | $\pm 3$ | $\pm 6$ | - | $\pm 3$ | $\pm 6$ | - | \% |
| Output Voltage Noise | $e_{n p-p}$ | 0.1 Hz to 10 Hz (Note 7) | - | 10 | 15 | - | 10 | 15 | $\mu \mathrm{V}_{\mathrm{p}-\mathrm{p}}$ |
| Line Regulation (Note 2) |  | $\mathrm{V}_{\mathrm{IN}}=8 \mathrm{~V}$ to 33 V | - | 0.006 | 0.010 | - | 0.006 | 0.010 | \%/V |
| Load Regulation (Note 2) |  | $\mathrm{I}_{\mathrm{L}}=0$ to 10 mA | - | 0.005 | 0.010 | - | 0.006 | 0.010 | \%/mA |
| Turn-on Settling Time | ${ }^{\text {O }}$ ON | To $\pm 0.1 \%$ of final value | - | 5 | - | - | 5 | - | $\mu \mathrm{S}$ |
| Quiescent Supply Current | $\mathrm{I}_{\text {SY }}$ | No Load | - | 1.0 | 1.4 | - | 1.0 | 1.4 | mA |
| Load Current | $\mathrm{I}_{\mathrm{L}}$ |  | 10 | 21 | - | 10 | 21 | - | mA |
| Sink Current | $I_{S}$ | (Note 8) | -0.3 | -0.5 | - | -0.3 | -0.5 | - | mA |
| Short-Circuit Current | $I_{\text {SC }}$ | $V_{0}=0$ | - | 30 | - | - | 30 | - | mA |
| Temperature Voltage Output | $V_{T}$ | ( Note 3) | - | 630 | . - | - | 630 | - | mV |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{IN}}=+15 \mathrm{~V},-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq \pm 125^{\circ} \mathrm{C}$ for REF-02A and REF- $02,0^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+70^{\circ} \mathrm{C}$ for REF-02E and REF-02H, $\mathrm{I}_{\mathrm{L}}=0 \mathrm{~mA}$, unless otherwise noted.

|  |  |  | REF-02A/E |  |  | REF-02/H |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | MIN | TYP | MAX | UNITS |
| Ouput Voltage Change with Temperature (Notes 4, 5) | $\Delta V_{\text {OT }}$ | $\begin{aligned} & 0^{\circ} \mathrm{C} \leq \mathrm{T}_{A} \leq+70^{\circ} \mathrm{C} \\ & -55^{\circ} \mathrm{C} \leq \mathrm{T}_{A} \leq+125^{\circ} \mathrm{C} \end{aligned}$ | - | $\begin{aligned} & 0.02 \\ & 0.06 \end{aligned}$ | $\begin{aligned} & 0.06 \\ & 0.15 \end{aligned}$ | - | $\begin{aligned} & 0.07 \\ & 0.18 \end{aligned}$ | $\begin{aligned} & 0.17 \\ & 0.45 \end{aligned}$ | \% |
| Output Voltage <br> Temperature Coefficient | TCV | (Note 6) | - | 3 | 8.5 | - | 10 | 25 | ppm $/{ }^{\circ} \mathrm{C}$ |
| Change in $\mathrm{V}_{\mathbf{O}}$ Temperature Coefficient with Output Adjustment |  | $R_{p}=10 k \Omega$ | - | 0.7 | - | - | 0.7 | - | ppm/\% |
| Line Regulation $\left(\mathrm{V}_{\mathrm{IN}}=8\right. \text { to 33V) (Note 2) }$ |  | $\begin{aligned} & 0^{\circ} \mathrm{C} \leq \mathrm{T}_{A} \leq+70^{\circ} \mathrm{C} \\ & -55^{\circ} \mathrm{C} \leq T_{A} \leq+125^{\circ} \mathrm{C} \end{aligned}$ | - | $\begin{aligned} & 0.007 \\ & 0.009 \\ & \hline \end{aligned}$ | $\begin{aligned} & 0.012 \\ & 0.015 \\ & \hline \end{aligned}$ | - | $\begin{aligned} & 0.007 \\ & 0.009 \\ & \hline \end{aligned}$ | $\begin{aligned} & 0.012 \\ & 0.015 \end{aligned}$ | \%/V |
| Load Regulation ( $I_{L}=0$ to 8 mA ) (Note 2) |  | $\begin{aligned} & 0^{\circ} \mathrm{C} \leq \mathrm{T}_{A} \leq+70^{\circ} \mathrm{C} \\ & -55^{\circ} \mathrm{C} \leq \mathrm{T}_{A} \leq+125^{\circ} \mathrm{C} \end{aligned}$ | - | $\begin{aligned} & 0.006 \\ & 0.007 \end{aligned}$ | $\begin{aligned} & 0.010 \\ & 0.012 \end{aligned}$ | - | $\begin{aligned} & 0.007 \\ & 0.009 \end{aligned}$ | $\begin{aligned} & 0.012 \\ & 0.015 \end{aligned}$ | \%/mA |
| Temperature Voltage Output Temperature Coefficient | $\mathrm{TCV}_{\text {T }}$ | (Note 3) | - | 2.1 | - | - | 2.1 | - | $\mathrm{mV} /{ }^{\circ} \mathrm{C}$ |

## NOTES:

1. Guaranteed by design.
2. Line and Load Regulation specifications include the effect of self heating.
3. Limit current in or out of pin 3 to 50 nA and capacitance on pin 3 to 30 pF .
4. $\Delta \mathrm{V}_{\mathrm{OT}}$ is defined as the absolute difference between the maximum output voltage and the minimum output voltage over the specified temperature range expressed as a percentage of 5 V .

$$
\Delta V_{O T}=\left|\frac{V_{\text {MAX }}-V_{\text {MIN }}}{5 V}\right| \times 100
$$

5. $\Delta V_{\text {OT }}$ specification applies trimmed to +5.000 V or untrimmed.
6. $T C V_{O}$ is defined as $\Delta V_{O T}$ divided by the temperature range, i.e.,

$$
\mathrm{TCV}_{\mathrm{O}}=\frac{\Delta \mathrm{V}_{\mathrm{OT}}}{70^{\circ} \mathrm{C}}
$$

7. Sample Tested.
8. During sink current test the driver meets the output voltage specified.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{I N}=+15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | REF-02C |  |  | REF-02D |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | UNITS |
| Output Voltage | $\mathrm{V}_{0}$ | $\mathrm{I}_{\mathrm{L}}=0 \mathrm{~mA}$ | 4.950 | 5.000 | 5.050 | 4.900 | 5.000 | 5.100 | V |
| Output Adjustment Range | $\Delta V_{\text {trim }}$ | $R_{p}=10 \mathrm{k} \Omega$ | $\pm 2.7$ | $\pm 6.0$ | - | $\pm 2.0$ | $\pm 6.0$ | - | \% |
| Output Voltage Noise | $\theta_{\text {np-p }}$ | 0.1 Hz to 10 Hz (Note 7) | - | 12 | 18 | - | 12 | - | $\mu \mathrm{V}_{\text {p-p }}$ |
| Line Regulation (Note 2) |  | $\mathrm{V}_{\text {IN }}=8 \mathrm{~V}$ to 30 V | - | 0.009 | 0.015 | - | 0.010 | 0.04 | \%/V |
| Load Regulation (Note 2) |  | $\begin{aligned} & I_{L}=0 \text { to } 8 \mathrm{~mA} \\ & I_{L}=0 \text { to } 4 \mathrm{~mA} \end{aligned}$ | - | $0.006$ $-$ | 0.015 - | - | $\begin{array}{r} - \\ 0.015 \\ \hline \end{array}$ | $0 . \overline{24}$ | \%/mA |
| Turn-on Settling Time | ${ }^{\text {ton }}$ | To $\pm 0.1 \%$ of final value | - | 5 | - | - | 5 | - | $\mu \mathrm{s}$ |
| Quiescent Supply Current | $\mathrm{I}_{\mathrm{SY}}$ | No Load | - | 1.0 | 1.6 | - | 1.0 | 2.0 | mA |
| Load Current | $I_{L}$ |  | 8 | 21 | - | 8 | 21 | - | mA |
| Sink Current | Is | (Note 8) | -0.3 | -0.5 | - | -0.3 | -0.5 | - | mA |
| Short-Circuit Current | ${ }_{\text {ISC }}$ | $\mathrm{V}_{\mathrm{O}}=0$ | - | 30 | - | - | 30 | - | mA |
| Temperature Voltage Output | $V_{T}$ | (Note 3) | - | 630 | - | - | 630 | - | mV |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{I N}=+15 \mathrm{~V} ; \mathrm{I}_{\mathrm{L}}=0 \mathrm{~mA}, 0^{\circ} \mathrm{C} \leq T_{A} \leq+70^{\circ} \mathrm{C}$ for REF- $02 \mathrm{CJ}, \mathrm{CZ}, \mathrm{DJ}, \mathrm{DZ}, \mathrm{DP} ;-40^{\circ} \mathrm{C} \leq \mathrm{T}_{A} \leq+85^{\circ} \mathrm{C}$ for REF-02CP, CS; unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | REF-02C |  |  | REF-02D |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Ouput Voltage Change with Temperature | $\Delta V_{\text {OT }}$ | (Notes 4 and 5) | - | 0.14 | 0.45 | - | 0.49 | 1.7 | \% |
| Output Voltage Temperature Coefficient | TCV | (Note 6) | - | 20 | 65 | - | 70 | 250 | ppm $/{ }^{\circ} \mathrm{C}$ |
| Change in $\mathrm{V}_{\mathrm{O}}$ Temperature Coefficient With Output Adjustment |  | $R_{p}=10 \mathrm{k} \Omega$ | - | 0.7 | - | - | 0.7 | - | ppm/\% |
| Line Regulation (Note 2) |  | $\mathrm{V}_{1 \mathrm{~N}}=8 \mathrm{~V}$ to 30 V | - | 0.011 | 0.018 | - | 0.012 | 0.05 | \%/V |
| Load Regulation (Note 2) |  | $\mathrm{I}_{\mathrm{L}}=0$ to 5 mA | - | 0.008 | 0.018 | - | 0.016 | 0.05 | \%/mA |
| Temperature Voltage Output Temperature Coefficient | TCV ${ }_{\text {T }}$ | (Note 3) | - | 2.1 | - | - | 2.1 | - | $\mathrm{mV} /{ }^{\circ} \mathrm{C}$ |

## NOTES:

1. Guaranteed by design.
2. Line and Load Regulation specifications include the effect of self heating.
3. Limit current in or out of pin 3 to 50 nA and capacitance on pin 3 to 30 pF .
4. $\Delta \mathrm{V}_{\mathrm{OT}}$ is defined as the absolute difference between the maximum output voltage and the minimum output voltage over the specified temperature range expressed as a percentage of 5 V .

$$
\Delta V_{O T}=\left|\frac{V_{M A X}-V_{M I N}}{5 V}\right| \times 100
$$

5. $\Delta V_{O T}$ specification applies trimmed to +5.000 V or untrimmed.
6. $T C V_{O}$ is defined as $\Delta V_{O T}$ divided by the temperature range, i.e.,

$$
\mathrm{TCV}_{\mathrm{O}}=\frac{\Delta \mathrm{V}_{\mathrm{OT}}}{70^{\circ} \mathrm{C}}
$$

7. Sample Tested.
8. During sink current test the device meets the output voltage specified.

## REF43

## FEATURES

- +2.5 Volt Output . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 0.05 \%$ Max
- Low Temperature Coefficient . . . . . . . . . . . . . 10ppm/ ${ }^{\circ} \mathrm{C}$ Max
- Excellent Regulation
$\qquad$
$\qquad$
- Supply Current . . . . . . . . . . . . . . . . . . . . . . . . . . . . 450 4 A Max
- Temperature Voltage Output . . . . . . . . . . . . . . . . . . $+1.9 \mathrm{mV} /{ }^{\circ} \mathrm{C}$
- Operating Voltage Range .................... +4.5 V to +40 V
- Extended Industrial Temp Range . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
- Available in Die Form

ORDERING INFORMATION ${ }^{\dagger}$

|  | PACKAGE |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| TCV $_{0}$ | TO-99 | CERDIP | PLASTIC | LCC | OPERATING |
| TEMPERATURE |  |  |  |  |  |

- For devices processed in total compliance to MIL-STD-883, add /883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.


## GENERAL DESCRIPTION

The REF-43 is a low-power precision reference providing a stable +2.5 V output independent of variations in supply voltage, load conditions or ambient temperature. It is suitable as a reference level for 8,10 and 12-bit data acquisition systems, or wherever a stable, known voltage is required.

Tight output tolerances and low thermal drift are assured by zener-zap trimming of both output voltage and its temperature coefficient. A unique curvature correction circuit reduces the thermal curvature which is characteristic of many previous bandgap references.

## PIN CONNECTIONS



8-PIN CERDIP
(Z-Suffix)
8-PIN PLASTIC DIP
(P-Suffix)
8-PIN SO
(S-Suffix)
*RESERVED FOR FACTORY TESTING.
make no electrical connection to these pins.

## SIMPLIFIED SCHEMATIC



[^118] complete data sheet, call our fax retrieval system at 1-800-446-6212.

The REF-43 may be operated with supply voltages from +4.5 V to +40 V . The output voltage changes by less than $178 \mu \mathrm{~V}$ from one extreme of supply voltage to the other. With only $450 \mu \mathrm{~A}$ maximum quiescent current, the REF-43 is ideally suited to applications where power dissipation must be minimized, as in precision battery-powered equipment. The low supply current minimizes drift due to self-heating after power-up.

A temperature output provides a means of determining system ambient temperature. Applications of the REF-43 include A/D and D/A conversion, 4-20mA transmitter/receiver operation, log amplifiers, and power-supply regulators.
For a low-cost 2.5 V reference available in small-outline packages consult the REF-03 data sheet.

## ABSOLUTE MAXIMUM RATINGS (Note 1)

Operating Temperature Range
REF-43B (J, Z) ............................................. $-5^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
REF-43F (J, Z) ......................................... $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
REF-43G (J, Z, P, S) .................................. $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range ....................... $-65^{\circ} \mathrm{C}$ to $+175^{\circ} \mathrm{C}$
Junction Temperature Range ...................... $-65^{\circ} \mathrm{C}$ to $+175^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 sec ) ......................... $300^{\circ} \mathrm{C}$

| PACKAGE TYPE | $\theta_{\text {Ja }}$ (Note 2) | $\theta_{\text {Jc }}$ | UNITS |
| :---: | :---: | :---: | :---: |
| TO-99(J) | 150 | 18 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin Hermetic DIP (Z) | 148 | 16 | ${ }^{\circ} \mathrm{CN}$ |
| 8-Pin Plastic DIP (P) | 103 | 43 | ${ }^{\circ} \mathrm{C}$ W |
| 20-Contact LCC (RC) | 98 | 38 | ${ }^{\circ} \mathrm{C}$ W |
| $8-\mathrm{Pin} \mathrm{SO}(\mathrm{S})$ | 158 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTES:

1. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
2. $\Theta_{\mathrm{ja}}$ is specified for worst case mounting conditions, i.e., $\boldsymbol{\theta}_{\mathrm{ja}}$ is specified for device in socket for TO, CerDIP, P-DIP, and LCC packages; $\boldsymbol{\theta}_{\mathrm{jA}}$ is specified for device soldered to printed circuit board for SO package.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{IN}}=+5 \mathrm{~V}, \mathrm{I}_{\mathrm{L}}=0 \mathrm{~mA}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | REF-43B |  |  | REF-43F |  |  | REF-43G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Output Voltage Tolerance |  | No Load | - | 0.04 | 0.1 | - | 0.02 | 0.06 | - | 0.04 | 0.1 | \% |
| Output Voltage | $\mathrm{v}_{0}$ | No Load | 2.4975 | 2.5000 | 2.5025 | 2.4985 | 2.5000 | 2.5015 | 2.4975 | 2.5000 | 2.5025 | V |
| Output Voltage Noise | $e_{\text {nRMS }}$ | 10 Hz to 1 kHz (Note 1) | - | 7 | 10 | - | 7 | 10 | - | 7 | 10 | $\mu \mathrm{V}_{\text {RMS }}$ |
| Line Regulation |  | $\begin{aligned} & \mathrm{V}_{I N}=+4.5 \mathrm{~V} \\ & \text { to }+40 \mathrm{~V} \end{aligned}$ | - | 0.8 | 2 | - | 0.8 | 2 | - | 0.8 | 2 | ppm/V |
| Load Regulation |  | $\begin{aligned} & I_{L}=0 \mathrm{~mA} \\ & \text { to } 10 \mathrm{~mA} \end{aligned}$ | - | 14 | 20 | - | 14 | 20 | - | 14 | 20 | ppm/mA |
| Quiescent Supply Current | $I_{\text {SY }}$ | No Load | - | 340 | 450 | - | 340 | 450 | - | 340 | 450 | $\mu \mathrm{A}$ |
| Load Current (Sourcing) | $I_{L}$ | (Note 2) | 10 | 20 | - | 10 | 20 | - | 10 | 20 | - | mA |
| Load Current (Sinking) | $I_{s}$ | (Note 3) | - | -1.2 | - | - | -1.2 | - | - | -1.2 | - | mA |
| Short-Circuit Output Current | $\mathrm{I}_{\mathrm{sc}}$ | Output Shorted to Ground | - | 60 | - | - | 60 | - | - | 60 | - | mA |
| Temperature <br> Voltage <br> Output | $V_{\text {TEMP }}$ |  | - | 567 | - | - | 567 | - | - | 567 | - | mV |
| Vout Adjust Range |  |  | - | $\pm 95$ | - | - | $\pm 95$ | - | - | $\pm 95$ | - | mV |
| Long-Term Output Drift | $\Delta \mathrm{V}_{\mathrm{O}}$ /Time | (Note 4) | - | 1 | - | - | 1 | - | - | 1 | - | ppm/month |

## NOTES:

1. Guaranteed but not tested.
2. Guaranteed by load regulation test.
3. Output remains within $2.5 \mathrm{~V} \pm 2.5 \mathrm{mV}$.
4. Calculated from accelerated life tests at $T_{A}=150^{\circ} \mathrm{C}$. Activation energy $=0.7 \mathrm{eV}$.

ELECTRICAL CHARACTERISTICS at $V_{I N}=+5 \mathrm{~V}, \mathrm{I}_{\mathrm{L}}=0 \mathrm{~mA},-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ for the REF- 43 B and $-40^{\circ} \mathrm{C} \leq T_{A} \leq+85^{\circ} \mathrm{C}$ for the REF-43F/G, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | REF-43B |  |  | REF-43F |  |  | REF-43G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Output Voltage Tolerance |  | No Load | - | 0.1 | 0.2 | - | 0.06 | 0.12 | - | 0.1 | 0.2 | \% |
| Output Voltage | $V_{0}$ | No Load | 2.495 | 2.500 | 2.505 | 2.497 | 2.500 | 2.503 | 2.495 | 2.500 | 2.505 | V |
| Output Voltage <br> Temperature Coefficient | $\mathrm{TCV}_{0}$ | $\begin{aligned} & -55^{\circ} \mathrm{C} \leq \mathrm{T}_{A} \leq+125^{\circ} \mathrm{C} \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{A} \leq+85^{\circ} \mathrm{C} \\ & \text { (Note 1) } \end{aligned}$ | - | 6 | 10 | - | $6$ | $\overline{10}$ | - | 10 | 25 | ppm/ ${ }^{\circ} \mathrm{C}$ |
| Line Regulation |  | $\begin{aligned} & V_{I N}=+4.5 \mathrm{~V} \\ & \text { to }+40 \mathrm{~V} \end{aligned}$ | - | 1 | 3 | - | 1 | 3 | - | 1 | 3 | ppm/V |
| Load Regulation |  | $\begin{aligned} & \mathrm{I}_{\mathrm{L}}=0 \mathrm{~mA} \\ & \text { to } 10 \mathrm{~mA} \end{aligned}$ | - | 25 | 40 | - | 20 | 35 | - | 25 | 40 | ppm/mA |
| Quiescent Supply Current | Isy | No Load | - | 400 | 600 | - | 400 | 600 | - | 400 | 600 | $\mu \mathrm{A}$ |
| Load Current (Sourcing) | L | (Note 2) | 10 | 20 | - | 10 | 20 | - | 10 | 20 | - | mA |
| Temperature Hysteresis of Output Voltage |  | $\Delta T= \pm 25^{\circ} \mathrm{C}$ | - | 100 | - | - | 100 | - | - | 100 | - | $\mu \mathrm{V}$ |

Temperature


Output Tempco

## NOTES:

1. Output voltage temperature coefficient is measured by the box method. The tempco is defined as the slope of the diagonal of a box drawn around the output voltage plotted against temperature. $V_{\text {OUT }}$ is measured at $T_{\text {MIN }}$, $25^{\circ} \mathrm{C}$ and $\mathrm{T}_{\text {MAX }}$ for the applicable temperature range. The lowest of these three readings is subtracted from the highest reading and the resulting difference is divided by ( $T_{\text {MAX }}-T_{\text {MIN }}$ ).
2. Guaranteed by Load Regulation test.

## BURN-IN CIRCUIT



## OUTPUT VOLTAGE TRIM METHOD



## FEATURES

Initial Accuracy: $\pm \mathbf{2 m V}$ max
Temperature Coefficient: 5 ppm/ ${ }^{\circ} \mathbf{C}$ max
Low Supply Current: $45 \mu \mathrm{~A}$ max
Low Dropout Voltage
Load Regulation: 4 ppm/mA
Line Regulation: 4 ppm/V
High Output Current: $\mathbf{3 0} \mathbf{m A}$
Short Circuit Protection
Shutdown Mode
APPLICATIONS
Portable Instrumentation
A-to-D and D-to-A Converters
Smart Sensors
Solar Powered Applications
Loop Current Powered Instruments

## GENERAL DESCRIPTION

REF19x series precision bandgap voltage references utilize a patented temperature drift curvature correction circuit and laser trimming of highly stable thin-film resistors to achieve a very low temperature coefficient and a high initial accuracy.
The REF19x series are micropower, Low Dropout Voltage (LDV) devices providing a stable output voltage from supplies as low as 100 mV above the output voltage and consuming less than $45 \mu \mathrm{~A}$ of supply current. In shutdown mode, which is enabled by applying a low TTL or CMOS level to the shutdown pin, the output is turned off and supply current is further reduced to less than $15 \mu \mathrm{~A}$.
The REF19x series references are specified over the extended industrial temperature range ( $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ) and High Operating Temperature (HOT) range $\left(-40^{\circ} \mathrm{C}\right.$ to $+125^{\circ} \mathrm{C}$ ) for applications such as automotive.

All grades are available in 8-pin SOIC and PDIP. Products are also available in die form. TSSOP 8-pin available Q4, 1994.

## PIN CONFIGURATIONS

8-Lead Narrow-Body SO (S Suffix)


8-Lead Epoxy DIP (P Suffix)


NC = NO CONNECT
TP PINS ARE FACTORY TEST POINTS NO USER CONNECTION

## REF19x Series

## REF192-SPECIFICATIONS



| Parameter | Symbol | Condition | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INITIAL ACCURACY <br> "E" Grade <br> "F" Grade <br> "G" Grade | Vo | $\mathrm{I}_{\text {OUT }}=1 \mathrm{~mA}$ | $\begin{aligned} & 2.498 \\ & 2.495 \\ & 2.490 \\ & \hline \end{aligned}$ | 2.500 | $\begin{aligned} & 2.502 \\ & 2.505 \\ & 2.510 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \end{aligned}$ |
| LINE REGULATION <br> "E" Grade <br> "F \& G" Grades <br> "E" Grade <br> "F \& G" Grades | $\Delta \mathrm{V}_{\mathrm{O}} / \Delta \mathrm{V}_{\mathrm{IN}}$ <br> $\Delta \mathrm{V}_{\mathrm{O}} / \Delta \mathrm{I}_{\text {LOAD }}$ | $\begin{aligned} & 2.6 \mathrm{~V} \leq \mathrm{V}_{\mathrm{S}} \leq 15 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=1 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{S}}=3.8 \mathrm{~V}, 0 \leq \mathrm{I}_{\text {OUT }} \leq 30 \mathrm{~mA} \end{aligned}$ |  | $\begin{aligned} & 2 \\ & 4 \\ & 2 \\ & 4 \\ & \hline \end{aligned}$ | $\begin{aligned} & 4 \\ & 8 \\ & 4 \\ & 8 \\ & \hline \end{aligned}$ | ppm/V <br> ppm/V <br> $\mathrm{ppm} / \mathrm{mA}$ <br> $\mathrm{ppm} / \mathrm{mA}$ |
| DROPOUT VOLTAGE | $\mathrm{V}_{\mathrm{s}}-\mathrm{V}_{\mathrm{o}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=3.0 \mathrm{~V}, \mathrm{I}_{\mathrm{LOAD}}=10 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{S}}=3.8 \mathrm{~V}, \mathrm{I}_{\mathrm{LOAD}}=30 \mathrm{~mA} \end{aligned}$ |  |  | $\begin{aligned} & 0.50 \\ & 1.30 \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |
| LONG-TERM STABILITY | $\Delta \mathrm{V}_{\mathrm{O}}$ | 1000 Hours @ +150 ${ }^{\circ} \mathrm{C}$ |  | 2 |  | mV |
| NOISE VOLTAGE | $\mathrm{e}_{\mathrm{N}}$ | 0.1 Hz to 10 Hz |  | 50 |  | $\mu \mathrm{V}$ p-p |

ELECTRICAL CHARACTERISTICS $\left(\mathrm{v}_{\mathrm{s}}=+2.65 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{I}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}\right.$ unless othewwise noted)

| Parameter | Symbol | Condition | Min | Typ | Max |
| :--- | :--- | :--- | :--- | :--- | :--- |
| TEMPERATURE COEFFICIENT <br> "E" Grade |  |  |  | Units |  |
| "F"Grade |  |  |  |  |  |
| "G" Grade |  |  |  |  |  |

ELECTRICAL CHARACTERISTICS (@ $V_{s}=+2.7 \mathrm{~V},-40^{\circ} \leq \mathrm{I}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ unless otherwise noted)

| Parameter | Symbol | Condition | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TEMPERATURE COEFFICIENT <br> "E" Grade <br> "F" Grade <br> "G" Grade | $\mathrm{TCV}_{0} /{ }^{\circ} \mathrm{C}$ | $\mathrm{I}_{\text {OUT }}=1 \mathrm{~mA}$ |  |  | $\begin{aligned} & 7 \\ & 15 \\ & 25 \end{aligned}$ | $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ <br> ppm $/{ }^{\circ} \mathrm{C}$ <br> $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ |
| LINE REGULATION <br> "E" Grade <br> "F \& G" Grades <br> "E" Grade <br> "F \& G" Grades | $\begin{aligned} & \Delta \mathrm{V}_{\mathrm{O}} / \Delta \mathrm{V}_{\mathrm{IN}} \\ & \Delta \mathrm{~V}_{\mathrm{O}} / \Delta \mathrm{I}_{\mathrm{LOAD}} \end{aligned}$ | $\begin{aligned} & 2.7 \mathrm{~V} \leq \mathrm{V}_{\mathrm{S}} \leq 15 \mathrm{~V}, \mathrm{I}_{\mathrm{OUT}}=1 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{S}}=3.8 \mathrm{~V}, 0 \leq \mathrm{I}_{\text {OUT }} \leq 20 \mathrm{~mA} \end{aligned}$ |  | $\begin{aligned} & 10 \\ & 20 \\ & 10 \\ & 20 \\ & \hline \end{aligned}$ | $\begin{aligned} & 20 \\ & 30 \\ & 20 \\ & 30 \\ & \hline \end{aligned}$ | ppm/V <br> ppm/V <br> $\mathrm{ppm} / \mathrm{mA}$ <br> ppm/mA |
| DROPOUT VOLTAGE | $\mathrm{V}_{\mathrm{s}}-\mathrm{V}_{\mathrm{o}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=3.10 \mathrm{~V}, \mathrm{I}_{\mathrm{LOAD}}=10 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{S}}=3.95 \mathrm{~V}, \mathrm{I}_{\mathrm{LOAD}}=30 \mathrm{~mA} \end{aligned}$ |  |  | $\begin{aligned} & 0.60 \\ & 1.45 \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |
| SHUTDOWN PIN <br> Logic High Input Voltage Logic High Input Current Logic Low Input Voltage Logic Low Input Current | $\begin{aligned} & \mathrm{V}_{\mathrm{H}} \\ & \mathrm{I}_{\mathrm{L}} \\ & \mathrm{~V}_{\mathrm{L}} \\ & \mathrm{I}_{\mathrm{L}} \end{aligned}$ | $\mathrm{V}_{\mathrm{S}}=3.3 \mathrm{~V}$ | 2.4 |  | $\begin{aligned} & -5 \\ & 0.8 \\ & -5 \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mu \mathrm{~A} \\ & \mathrm{~V} \\ & \mu \mathrm{~A} \\ & \hline \end{aligned}$ |
| SUPPLY CURRENT <br> Sleep Mode |  | $\mathrm{V}_{\mathrm{S}}=3.3 \mathrm{~V}$ |  |  | $\begin{aligned} & 45 \\ & 15 \end{aligned}$ | $\begin{aligned} & \mu \mathrm{A} \\ & \mu \mathrm{~A} \\ & \hline \end{aligned}$ |

[^119]This information applies to a product under development. Its characteristics and specifications are subject to change without notice.
Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

## REF193-SPECIFICATIONS

ELECTRICAL CHARACTERISTICS (e $\mathrm{v}_{s}=+3.10 \mathrm{~V}, \mathrm{~T}_{A}=+25^{\circ}$ unless thememise noted)

| Parameter | Symbol | Condition | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INITIAL ACCURACY "G" Grade | $\mathrm{V}_{\mathrm{O}}$ | $\mathrm{I}_{\text {OuT }}=1 \mathrm{~mA}$ | 2.990 | 3.0 | 3.010 | V |
| LINE REGULATION "G" Grade | $\begin{aligned} & \Delta \mathrm{V}_{\mathrm{O}} / \Delta \mathrm{V}_{\mathrm{IN}} \\ & \Delta \mathrm{~V}_{\mathrm{O}} / \Delta \mathrm{I}_{\mathrm{LOAD}} \end{aligned}$ | $\begin{aligned} & 3.05 \mathrm{~V} \leq \mathrm{V}_{\mathrm{S}} \leq 15 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=1 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{S}}=4.3 \mathrm{~V}, 0 \leq \mathrm{I}_{\text {OUT }} \leq 30 \mathrm{~mA} \end{aligned}$ |  | $\begin{aligned} & 4 \\ & 4 \end{aligned}$ | $\begin{aligned} & 8 \\ & 8 \end{aligned}$ | ppm/V ppm/mA |
| DROPOUT VOLTAGE | $\mathrm{V}_{\mathrm{s}}-\mathrm{V}_{\mathrm{O}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=3.50 \mathrm{~V}, \mathrm{I}_{\mathrm{LOAD}} \\ & \mathrm{~V}_{\mathrm{S}}=4.30 \mathrm{~mA} \\ & \hline \end{aligned}$ |  |  | $\begin{aligned} & 0.50 \\ & 1.30 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |
| LONG-TERM STABILITY | $\Delta \mathrm{V}_{\text {O }}$ | 1000 Hours @ $+150^{\circ} \mathrm{C}$ |  | 2 |  | mV |
| NOISE VOLTAGE | $\mathrm{e}_{\mathrm{N}}$ | 0.1 Hz to 10 Hz |  | 50 |  | $\mu \mathrm{V}$ p-p |

ELECTRICAL CHARACTERISTICS ( $\mathrm{V}_{\mathrm{s}}=+3.15 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{I}_{\Lambda} \leq+85^{\circ} \mathrm{Cunless}$ otherwise noted)

| Parameter | Symbol | Condition | Min | Typ |
| :--- | :--- | :--- | :--- | :--- |
| TEMPERATURE COEFFICIENT <br> "G" Grade |  |  |  | Max | Units

## ELECTRICAL CHARACTERISTICS © $\mathrm{V}_{5}=+3.20 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ unless otherwise noted)

| Parameter | Symbol | Condition | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TEMPERATURE COEFFICIENT <br> "G" Grade | $\mathrm{TCV}_{0}{ }^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{OUT}}=1 \mathrm{~mA}$ |  |  | 25 | $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ |
| LINE REGULATION "G" Grade | $\begin{aligned} & \Delta \mathrm{V}_{\mathrm{O}} / \Delta \mathrm{V}_{\mathrm{IN}} \\ & \Delta \mathrm{~V}_{\mathrm{O}} / \Delta \mathrm{I}_{\mathrm{LOAD}} \end{aligned}$ | $\begin{aligned} & 3.05 \mathrm{~V} \leq \mathrm{V}_{\mathrm{S}} \leq 15 \mathrm{~V}, \mathrm{I}_{\mathrm{OUT}}=1 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{S}}=4.3 \mathrm{~V}, 0 \leq \mathrm{I}_{\text {OUT }} \leq 20 \mathrm{~mA} \end{aligned}$ |  | $\begin{aligned} & 20 \\ & 20 \\ & \hline \end{aligned}$ | $\begin{array}{r} 30 \\ 30 \\ \hline \end{array}$ | ppm/V <br> ppm/mA |
| DROPOUT VOLTAGE | $\mathrm{V}_{\mathrm{s}}-\mathrm{V}_{\mathrm{O}}$ | $\begin{aligned} \mathrm{V}_{\mathrm{S}} & =3.60 \mathrm{~V}, \mathrm{I}_{\mathrm{LOAD}} \\ \mathrm{~V}_{\mathrm{S}} & =4.45 \mathrm{~mA} \\ \mathrm{~V}, \mathrm{I}_{\mathrm{LOAD}} & =30 \mathrm{~mA} \end{aligned}$ |  |  | $\begin{aligned} & 0.60 \\ & 1.45 \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |
| SHUTDOWN PIN <br> Logic High Input Voltage Logic High Input Current Logic Low Input Voltage Logic Low Input Current | $\begin{aligned} & \mathrm{V}_{\mathrm{H}} \\ & \mathrm{I}_{\mathrm{L}} \\ & \mathrm{~V}_{\mathrm{L}} \\ & \mathrm{I}_{\mathrm{L}} \\ & \hline \end{aligned}$ | $\mathrm{V}_{\mathrm{S}}=3.3 \mathrm{~V}$ | 2.4 |  | $\begin{aligned} & -5 \\ & 0.8 \\ & -5 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mu \mathrm{~A} \\ & \mathrm{~V} \\ & \mu \mathrm{~A} \\ & \hline \end{aligned}$ |
| SUPPLY CURRENT <br> Sleep Mode |  | $\mathrm{V}_{\mathrm{S}}=3.3 \mathrm{~V}$ |  |  | $\begin{aligned} & 45 \\ & 15 \end{aligned}$ | $\begin{aligned} & \mu \mathrm{A} \\ & \mu \mathrm{~A} \\ & \hline \end{aligned}$ |

Specifications subject to change without notice.

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

## REF19x Series

## REF194-SPECIFICATIONS <br> 

| Parameter | Symbol | Condition | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INITIAL ACCURACY <br> "E" Grade <br> "F" Grade <br> "G" Grade | $\mathrm{V}_{0}$ | $\mathrm{I}_{\text {OUT }}=1 \mathrm{~mA}$ | $\begin{aligned} & 4.498 \\ & 4.495 \\ & 4.490 \end{aligned}$ | 4.5 | $\begin{aligned} & 4.502 \\ & 4.505 \\ & 4.510 \end{aligned}$ |  |
| LINE REGULATION <br> "E" Grade <br> "F \& G" Grades <br> "E" Grade <br> "F \& G" Grades | $\begin{aligned} & \Delta \mathrm{V}_{\mathrm{O}} / \Delta \mathrm{V}_{\mathrm{IN}} \\ & \Delta \mathrm{~V}_{\mathrm{o}} / \Delta \mathrm{I}_{\mathrm{LOAD}} \end{aligned}$ | $\begin{aligned} & 4.6 \mathrm{~V} \leq \mathrm{V}_{\mathrm{S}} \leq 15 \mathrm{~V}, \mathrm{I}_{\mathrm{OUT}}=1 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{S}}=5.8 \mathrm{~V}, 0 \leq \mathrm{I}_{\mathrm{OUT}} \leq 30 \mathrm{~mA} \end{aligned}$ |  | $\begin{aligned} & 2 \\ & 4 \\ & 2 \\ & 4 \end{aligned}$ | $\begin{aligned} & 4 \\ & 8 \\ & 4 \\ & 8 \end{aligned}$ | ppm/V <br> $\mathrm{ppm} / \mathrm{V}$ <br> $\mathrm{ppm} / \mathrm{mA}$ <br> $\mathrm{ppm} / \mathrm{mA}$ |
| DROPOUT VOLTAGE | $\mathrm{V}_{\mathrm{s}}-\mathrm{V}_{\mathrm{o}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=5.00 \mathrm{~V}, \mathrm{I}_{\mathrm{LOAD}}=10 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{S}}=5.8 \mathrm{~V}, \mathrm{I}_{\mathrm{LOAD}}=30 \mathrm{~mA} \end{aligned}$ |  |  | $\begin{aligned} & 0.50 \\ & 1.30 \end{aligned}$ | $\begin{aligned} & \mathrm{v} \\ & \mathrm{v} \end{aligned}$ |
| LONG-TERM STABILITY | $\Delta \mathrm{V}_{\mathrm{O}}$ | 1000 Hours @ $+150^{\circ} \mathrm{C}$ |  | 2 |  | mV |
| NOISE VOLTAGE | $\mathrm{e}_{\mathrm{N}}$ | 0.1 Hz to 10 Hz |  | 50 |  | $\mu \mathrm{V}$ p-p |

## ELECTRICAL CHARACTERIST|CS (@ $V_{S}=+4.65 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ unless otherwise noted)

| Parameter | Symbol | Condition | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TEMPERATURE COEFFICIENT <br> "E" Grade <br> " $F$ " Grade <br> "G" Grade | $\mathrm{TCV}_{0}{ }^{\circ} \mathrm{C}$ |  |  |  | $\begin{gathered} 5 \\ 10 \\ 25 \end{gathered}$ | $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ <br> ppm $/{ }^{\circ} \mathrm{C}$ <br> ppm $/{ }^{\circ} \mathrm{C}$ |
| LINE REGULATION <br> " $E$ " Grade <br> "F \& G" Grades <br> "E" Grade <br> "F \& G" Grades | $\begin{aligned} & \Delta \mathrm{V}_{\mathrm{O}} / \Delta \mathrm{V}_{\mathrm{IN}} \\ & \Delta \mathrm{~V}_{\mathrm{O}} / \Delta \mathrm{I}_{\text {LOAD }} \end{aligned}$ | $\begin{aligned} & 4.65 \mathrm{~V}_{\leq} \leq \mathrm{V}_{\mathrm{s}} \leq 15 \mathrm{~V}, \mathrm{I}_{\mathrm{OUT}}=1 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{S}}=580 \mathrm{~V}, 0 \leq \mathrm{I}_{\mathrm{OUT}} \leq 25 \mathrm{~mA} \end{aligned}$ |  | $\begin{aligned} & 4 \\ & 2 \\ & 4 \end{aligned}$ | $\begin{aligned} & 4 \\ & 8 \\ & 4 \\ & 8 \end{aligned}$ | ppm/V <br> ppm/V <br> $\mathrm{ppm} / \mathrm{mA}$ <br> $\mathrm{ppm} / \mathrm{mA}$ |
| DROPOUT VOLTAGE | $\mathrm{V}_{\mathrm{s}}-\mathrm{V}_{\mathrm{o}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=5.00 \mathrm{~V}, \mathrm{I}_{\mathrm{LOAD}}=10 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{S}}=5.8 \mathrm{~V}, \mathrm{I}_{\mathrm{LOAD}}=30 \mathrm{~mA} \end{aligned}$ |  |  | $\begin{aligned} & 0.50 \\ & 1.30 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |

## ELECTRICAL CHARACTERIST|CS (@ $V_{S}=+4.70 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ unless otherwise noted)

| Parameter | Symbol | Condition | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TEMPERATURE COEFFICIENT <br> "E" Grade <br> "F" Grade <br> "G" Grade | $\mathrm{TCV}_{0}{ }^{\circ}{ }^{\circ} \mathrm{C}$ | $\mathrm{I}_{\text {Out }}=1 \mathrm{~mA}$ |  |  | $\begin{aligned} & 7 \\ & 15 \\ & 25 \end{aligned}$ | $\begin{aligned} & \mathrm{ppm} /{ }^{\circ} \mathrm{C} \\ & \mathrm{ppm} /{ }^{\circ} \mathrm{C} \\ & \mathrm{ppm} /{ }^{\circ} \mathrm{C} \\ & \hline \end{aligned}$ |
| LINE REGULATION <br> "E" Grade <br> "F \& G" Grades <br> "E" Grade <br> "F \& G" Grades | $\begin{aligned} & \Delta \mathrm{V}_{\mathrm{O}} / \Delta \mathrm{V}_{\mathrm{IN}} \\ & \Delta \mathrm{~V}_{\mathrm{O}} / \Delta \mathrm{I}_{\mathrm{LOAD}} \end{aligned}$ | $\begin{aligned} & 4.70 \mathrm{~V} \leq \mathrm{V}_{\mathrm{S}} \leq 15 \mathrm{~V}, \mathrm{I}_{\mathrm{OUT}}=1 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{S}}=5.80 \mathrm{~V}, 0 \leq \mathrm{I}_{\mathrm{OUT}} \leq 20 \mathrm{~mA} \end{aligned}$ |  |  | $\begin{aligned} & 4 \\ & 8 \\ & 4 \\ & 8 \\ & \hline \end{aligned}$ | ppm/V <br> $\mathrm{ppm} / \mathrm{V}$ <br> ppm/mA <br> ppm/mA |
| DROPOUT VOLTAGE | $\mathrm{V}_{\mathrm{s}}-\mathrm{V}_{\mathrm{o}}$ | $\begin{aligned} \mathrm{V}_{\mathrm{S}} & =5.10 \mathrm{~V}, \mathrm{I}_{\mathrm{LOAD}} \\ \mathrm{~V}_{\mathrm{S}} & =5.95 \mathrm{~mA} \\ \mathrm{I}, \mathrm{I}_{\mathrm{LOAD}} & =30 \mathrm{~mA} \end{aligned}$ |  |  | $\begin{aligned} & 0.60 \\ & 1.45 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |
| SHUTDOWN PIN <br> Logic High Input Voltage Logic High Input Current Logic Low Input Voltage Logic Low Input Current | $\begin{aligned} & \mathrm{V}_{\mathrm{H}} \\ & \mathrm{I}_{\mathrm{L}} \\ & \mathrm{~V}_{\mathrm{L}} \\ & \mathrm{I}_{\mathrm{L}} \end{aligned}$ | $\mathrm{V}_{\mathrm{S}}=3.3 \mathrm{~V}$ | 2.4 |  | $\begin{aligned} & -5 \\ & 0.8 \\ & -5 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mu \mathrm{~A} \\ & \mathrm{~V} \\ & \mu \mathrm{~A} \\ & \hline \end{aligned}$ |
| SUPPLY CURRENT <br> Sleep Mode |  | $\mathrm{V}_{\mathrm{S}}=3.3 \mathrm{~V}$ |  |  | $\begin{aligned} & 45 \\ & 15 \end{aligned}$ | $\begin{aligned} & \mu \mathrm{A} \\ & \mu \mathrm{~A} \end{aligned}$ |

Specifications subject to change without notice.

This information applies to a product under development. Its characteristics and specifications are subject to change without notice.
Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

## REF195-SPECIFICATIONS <br> 

| Parameter | Symbol | Condition | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INITIAL ACCURACY <br> "E" Grade <br> "F" Grade <br> "G" Grade | $\mathrm{V}_{\mathrm{o}}$ | $\mathrm{I}_{\text {OUT }}=1 \mathrm{~mA}$ | $\begin{aligned} & 4.998 \\ & 4.995 \\ & 4.990 \end{aligned}$ | 5.0 | $\begin{aligned} & 5.002 \\ & 5.005 \\ & 5.010 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \end{aligned}$ |
| LINE REGULATION <br> "E" Grade <br> "F \& G" Grades <br> "E" Grade <br> "F \& G" Grades | $\begin{aligned} & \Delta \mathrm{V}_{\mathrm{o}} / \Delta \mathrm{V}_{\mathrm{IN}} \\ & \Delta \mathrm{~V}_{\mathrm{o}} / \Delta \mathrm{I}_{\mathrm{LOAD}} \end{aligned}$ | $\begin{aligned} & 5.10 \mathrm{~V} \leq \mathrm{V}_{\mathrm{S}} \leq 15 \mathrm{~V}, \mathrm{I}_{\mathrm{OUT}}=1 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{S}}=6.30 \mathrm{~V}, 0 \leq \mathrm{I}_{\mathrm{OUT}} \leq 30 \mathrm{~mA} \end{aligned}$ |  | $\begin{aligned} & 2 \\ & 4 \\ & 2 \\ & 4 \end{aligned}$ | $\begin{aligned} & 4 \\ & 8 \\ & 4 \\ & 8 \end{aligned}$ | ppm/V <br> $\mathrm{ppm} / \mathrm{V}$ <br> $\mathrm{ppm} / \mathrm{mA}$ <br> $\mathrm{ppm} / \mathrm{mA}$ |
| DROPOUT VOLTAGE | $\mathrm{V}_{5}-\mathrm{V}_{\mathrm{o}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=5.50 \mathrm{~V}, \mathrm{I}_{\mathrm{LOAD}}=10 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{S}}=6.30 \mathrm{~V}, \mathrm{I}_{\mathrm{LOAD}}=30 \mathrm{~mA} \end{aligned}$ |  |  | $\begin{aligned} & 0.50 \\ & 1.30 \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |
| LONG-TERM STABILITY | $\Delta \mathrm{V}_{\mathrm{o}}$ | 1000 Hours @ $+150^{\circ} \mathrm{C}$ |  | 2 |  | mV |
| NOISE VOLTAGE | $\mathrm{e}_{\mathrm{N}}$ | 0.1 Hz to 10 Hz |  | 50 |  | $\mu \mathrm{V}$ p-p |

ELECTRICAL CHARACTERISTICS (@ $V_{s}=+5.15 v,-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85 \circ^{\circ}$ unléss otherwise noted)

| Parameter | Symbol | Condition ${ }^{\text {a }}$ | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TEMPERATURE COEFFICIENT <br> "E" Grade <br> "F" Grade <br> "G" Grade | $\mathrm{TCV}_{0}{ }^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{OUR}}=1 \mathrm{~mA}$ |  |  | $\begin{aligned} & 5 \\ & 10 \\ & 25 \end{aligned}$ | $\begin{aligned} & \mathrm{ppm} /{ }^{\circ} \mathrm{C} \\ & \mathrm{ppm} /{ }^{\circ} \mathrm{C} \\ & \mathrm{ppm} /{ }^{\circ} \mathrm{C} \end{aligned}$ |
| LINE REGULATION <br> "E" Grade <br> "F \& G" Grades <br> "E" Grade <br> "F \& G" Grades | $\begin{aligned} & \Delta \mathrm{V}_{\mathrm{o}} / \mathrm{V}_{\mathrm{IN}} \\ & \Delta \mathrm{~V}_{\mathrm{O}} / \Delta \mathrm{I}_{\mathrm{LOAD}} \end{aligned}$ | $\begin{aligned} & 515 \mathrm{~V} \leq \mathrm{V}_{\mathrm{S}} \leq 15 \mathrm{~V}_{\mathrm{o}} \mathrm{I}_{\mathrm{OUT}}=1 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{S}}=6.30 \mathrm{y}, 0 \leq \mathrm{I}_{\mathrm{OUT}} \leq 25 \mathrm{~mA} \end{aligned}$ |  | $\begin{aligned} & 2 \\ & 4 \\ & 2 \\ & 4 \\ & \hline \end{aligned}$ | $\begin{aligned} & 4 \\ & 8 \\ & 4 \\ & 8 \\ & \hline \end{aligned}$ | ppm/V <br> ppm/V <br> $\mathrm{ppm} / \mathrm{mA}$ <br> $\mathrm{ppm} / \mathrm{mA}$ |
| DROPOUT VOLTAGE | $\mathrm{V}_{\mathrm{s}}-\mathrm{V}_{\mathrm{o}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=5.50 \mathrm{~V}, \mathrm{I}_{\mathrm{LOAD}}=10 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{S}}=6.30 \mathrm{~V}, \mathrm{I}_{\mathrm{LOAD}}=25 \mathrm{~mA} \end{aligned}$ |  |  | $\begin{aligned} & 0.50 \\ & 1.30 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |

ELECTRICAL CHARACTERISTICS (® $V_{S}=+5.20 \mathrm{~V},-40^{\circ} \leq \leq \mathrm{I}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ unless otherwise noted)

| Parameter | Symbol | Condition | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TEMPERATURE COEFFICIENT <br> "E" Grade <br> "F" Grade <br> "G" Grade | $\mathrm{TCV}_{0}{ }^{\circ} \mathrm{C}$ | $\mathrm{I}_{\text {OUT }}=1 \mathrm{~mA}$ |  |  | $\begin{aligned} & 7 \\ & 15 \\ & 25 \end{aligned}$ | $\begin{aligned} & \mathrm{ppm} /{ }^{\circ} \mathrm{C} \\ & \mathrm{ppm} /{ }^{\circ} \mathrm{C} \\ & \mathrm{ppm} /{ }^{\circ} \mathrm{C} \end{aligned}$ |
| LINE REGULATION <br> "E" Grade <br> "F \& G" Grades <br> "E" Grade <br> "F \& G" Grades | $\begin{aligned} & \Delta \mathrm{V}_{\mathrm{O}} / \Delta \mathrm{V}_{\mathrm{IN}} \\ & \Delta \mathrm{~V}_{\mathrm{O}} / \Delta \mathrm{I}_{\mathrm{LOAD}} \end{aligned}$ | $\begin{aligned} & 5.20 \mathrm{~V} \leq \mathrm{V}_{\mathrm{S}} \leq 15 \mathrm{~V}, \mathrm{I}_{\mathrm{OUT}}=1 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{S}}=6.450 \mathrm{~V}, 0 \leq \mathrm{I}_{\mathrm{OUT}} \leq 20 \mathrm{~mA} \end{aligned}$ |  | $\begin{aligned} & 2 \\ & 4 \\ & 2 \\ & 4 \\ & \hline \end{aligned}$ | $\begin{aligned} & 4 \\ & 8 \\ & 4 \\ & 8 \\ & \hline \end{aligned}$ | ppm/V <br> ppm/V <br> $\mathrm{ppm} / \mathrm{mA}$ <br> $\mathrm{ppm} / \mathrm{mA}$ |
| DROPOUT VOLTAGE | $\mathrm{V}_{\mathrm{s}}-\mathrm{V}_{\mathrm{o}}$ | $\begin{aligned} \mathrm{V}_{\mathrm{S}} & =5.60 \mathrm{~V}, \mathrm{I}_{\mathrm{LOAD}}=10 \mathrm{~mA} \\ \mathrm{~V}_{\mathrm{S}} & =6.45 \mathrm{~V}, \mathrm{I}_{\mathrm{LOAD}}=20 \mathrm{~mA} \end{aligned}$ |  |  | $\begin{aligned} & 0.60 \\ & 1.45 \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |
| SHUTDOWN PIN <br> Logic High Input Voltage Logic High Input Current Logic Low Input Voltage Logic Low Input Current | $\begin{aligned} & \mathrm{V}_{\mathrm{H}} \\ & \mathrm{I}_{\mathrm{L}} \\ & \mathrm{~V}_{\mathrm{L}} \\ & \mathrm{I}_{\mathrm{L}} \\ & \hline \end{aligned}$ | $\mathrm{V}_{\mathrm{S}}=5.5 \mathrm{~V}$ | 2.4 |  | $\begin{aligned} & -5 \\ & 0.8 \\ & -5 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mu \mathrm{~A} \\ & \mathrm{~V} \\ & \mu \mathrm{~A} \end{aligned}$ |
| SUPPLY CURRENT <br> Sleep Mode |  | $\mathrm{V}_{\mathrm{S}}=5.5 \mathrm{~V}$ |  |  | $\begin{array}{r} 45 \\ 15 \\ \hline \end{array}$ | $\begin{aligned} & \mu \mathrm{A} \\ & \mu \mathrm{~A} \end{aligned}$ |

Specifications subject to change without notice.

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

## REF19x Series

REF196-SPECIFICATIONS


| Parameter | Symbol | Condition | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INITIAL ACCURACY "G" Grade | $\mathrm{V}_{\mathrm{O}}$ | $\mathrm{I}_{\text {OUT }}=1 \mathrm{~mA}$ | 3.290 | 3.3 | 3.310 | V |
| LINE REGULATION "G" Grade | $\begin{aligned} & \Delta \mathrm{V}_{\mathrm{O}} / \Delta \mathrm{V}_{\mathrm{IN}} \\ & \Delta \mathrm{~V}_{\mathrm{O}} / \Delta \mathrm{I}_{\mathrm{LOAD}} \end{aligned}$ | $\begin{aligned} & 3.40 \mathrm{~V} \leq \mathrm{V}_{\mathrm{S}} \leq 15 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=1 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{S}}=3.80 \mathrm{~V}, 0 \leq \mathrm{I}_{\mathrm{OUT}} \leq 30 \mathrm{~mA} \end{aligned}$ |  | $\begin{array}{r} 4 \\ 4 \\ \hline \end{array}$ | $\begin{array}{r} 8 \\ 8 \\ \hline \end{array}$ | ppm/V <br> $\mathrm{ppm} / \mathrm{mA}$ |
| DROPOUT VOLTAGE | $\mathrm{V}_{\mathrm{s}}-\mathrm{V}_{\mathrm{o}}$ | $\begin{aligned} \mathrm{V}_{\mathrm{S}} & =3.80 \mathrm{~V}, \mathrm{I}_{\mathrm{LOAD}} \\ \mathrm{~V}_{\mathrm{S}} & =4.60 \mathrm{~mA} \\ \mathrm{I}, \mathrm{I}_{\mathrm{LOAD}} & =30 \mathrm{~mA} \end{aligned}$ |  |  | $\begin{aligned} & 0.50 \\ & 1.30 \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |
| LONG-TERM STABILITY | $\Delta \mathrm{V}_{0}$ | 1000 Hours @ $+150^{\circ} \mathrm{C}$ |  | 2 |  | mV |
| NOISE VOLTAGE | $\mathrm{e}_{\mathrm{N}}$ | 0.1 Hz to 10 Hz |  | 50 |  | $\mu \mathrm{V}$ p-p |

ELECTRICAL CHARACTERISTICS $\left(\begin{array}{l}V_{s}=+3.45 \\ \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \text { unless otherwise noteed) }\end{array}\right.$

| Parameter | Symbol | Condition | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TEMPERATURE COEFFICIENT "G" Grade | $\mathrm{TCV}_{0}{ }^{\circ}{ }^{\circ} \mathrm{C}$ | $\mathrm{I}_{\text {OUT }}=1 \mathrm{~mA}$ |  |  | 25 | ppm/ ${ }^{\circ} \mathrm{C}$ |
| LINE REGULATION "G" Grade | $\begin{aligned} & \Delta \mathrm{V}_{\mathrm{O}} / \Delta \mathrm{V}_{\mathrm{IN}} \\ & \Delta \mathrm{~V}_{\mathrm{O}} / \Delta \mathrm{I}_{\mathrm{LOAD}} \end{aligned}$ | $\begin{aligned} & 3.45 \mathrm{~V} \leq \mathrm{V}_{\mathrm{S}} \leq 15 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=1 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{S}}=3.80 \mathrm{~V}_{\mathrm{o}} 0 \leq \mathrm{I}_{\text {OUI }} \leq 25 \mathrm{~mA} \end{aligned}$ |  | $\begin{aligned} & 4 \\ & 4 \end{aligned}$ | $\begin{aligned} & 8 \\ & 8 \end{aligned}$ | ppm/V <br> $\mathrm{ppm} / \mathrm{mA}$ |
| DROPOUT VOLTAGE | $\mathrm{V}_{\mathrm{s}}-\mathrm{V}_{\mathrm{o}}$ | $\begin{aligned} & V_{S}=3.80 \mathrm{~V}, \mathrm{~L}_{\mathrm{LAD}}=10 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{S}}=4.60 \mathrm{~V}, \mathrm{I}_{\mathrm{LOAD}}=25 \mathrm{~mA} \end{aligned}$ |  |  | $\begin{aligned} & 0.50 \\ & 1.30 \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |

ELECTRICAL CHARACTERISTICS $\left(\odot \mathbb{S O}_{\mathrm{s}}=+3.50 \mathrm{~V}, 40 \mathrm{C} \leq \mathrm{M}_{\mathrm{L}} \leq+125^{\circ} \mathrm{C}\right.$ ulless otherwise noted)

| Parameter | Symbol | Condition ${ }^{\text {a }}$ | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TEMPERATURE COEFFICIENT "G" Grade | $\mathrm{TCV}_{0} /{ }^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{OUT}}=1 \mathrm{~mA}$ |  |  | 25 | $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ |
| LINE REGULATION "G" Grade | $\begin{aligned} & \Delta \mathrm{V}_{\mathrm{O}} / \Delta \mathrm{V}_{\mathrm{IN}} \\ & \Delta \mathrm{~V}_{\mathrm{O}} / \Delta \mathrm{I}_{\mathrm{LOAD}} \end{aligned}$ | $\begin{aligned} & 3.50 \mathrm{~V} \leq \mathrm{V}_{\mathrm{S}} \leq 15 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=1 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{S}}=3.80 \mathrm{~V}, 0 \leq \mathrm{I}_{\mathrm{OUT}} \leq 20 \mathrm{~mA} \end{aligned}$ | * |  |  | ppm/V <br> $\mathrm{ppm} / \mathrm{mA}$ |
| DROPOUT VOLTAGE | $\mathrm{V}_{\mathrm{S}}-\mathrm{V}_{\mathrm{O}}$ | $\begin{aligned} \mathrm{V}_{\mathrm{S}} & =3.90 \mathrm{~V}, \mathrm{I}_{\mathrm{LOAD}} \\ \mathrm{~V}_{\mathrm{S}} & =4.75 \mathrm{~mA} \\ \mathrm{~V}, \mathrm{I}_{\mathrm{LOAD}} & =20 \mathrm{~mA} \end{aligned}$ |  |  | $\begin{aligned} & 0.60 \\ & 1.45 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |
| SHUTDOWN PIN <br> Logic High Input Voltage Logic High Input Current Logic Low Input Voltage Logic Low Input Current | $\begin{aligned} & \mathrm{V}_{\mathrm{H}} \\ & \mathrm{I}_{\mathrm{L}} \\ & \mathrm{~V}_{\mathrm{L}} \\ & \mathrm{I}_{\mathrm{L}} \\ & \hline \end{aligned}$ | $\mathrm{V}_{\mathrm{S}}=5.5 \mathrm{~V}$ | 2.4 |  | $\begin{aligned} & -5 \\ & 0.8 \\ & -5 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mu \mathrm{~A} \\ & \mathrm{~V} \\ & \mu \mathrm{~A} \\ & \hline \end{aligned}$ |
| SUPPLY CURRENT <br> Sleep Mode |  | $\mathrm{V}_{\mathrm{S}}=5.5 \mathrm{~V}$ |  |  | $\begin{aligned} & 45 \\ & 15 \end{aligned}$ | $\begin{aligned} & \mu \mathrm{A} \\ & \mu \mathrm{~A} \end{aligned}$ |

[^120]This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

## REF198-SPECIFICATIONS <br> 

| Parameter | Symbol | Condition | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INITIAL ACCURACY <br> "E" Grade <br> " F " Grade <br> "G" Grade | $\mathrm{V}_{\mathrm{o}}$ | $\mathrm{I}_{\text {OUT }}=1 \mathrm{~mA}$ | $\begin{aligned} & 4.094 \\ & 4.091 \\ & 4.086 \end{aligned}$ | 4.096 | $\begin{aligned} & 4.098 \\ & 4.101 \\ & 4.106 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \end{aligned}$ |
| LINE REGULATION <br> "E" Grade <br> "F \& G" Grades <br> " $E$ " Grade <br> "F \& G" Grades | $\begin{aligned} & \Delta \mathrm{V}_{\mathrm{O}} / \Delta \mathrm{V}_{\mathrm{IN}} \\ & \Delta \mathrm{~V}_{\mathrm{o}} / \Delta \mathrm{I}_{\mathrm{LOAD}} \end{aligned}$ | $\begin{aligned} & 4.2 \mathrm{~V} \leq \mathrm{V}_{\mathrm{S}} \leq 15 \mathrm{~V}, \mathrm{I}_{\mathrm{OUT}}=1 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{S}}=5.4 \mathrm{~V}, 0 \leq \mathrm{I}_{\mathrm{OUT}} \leq 30 \mathrm{~mA} \end{aligned}$ |  |  | $\begin{aligned} & 4 \\ & 8 \\ & 4 \\ & 8 \end{aligned}$ | ppm/V <br> ppm/V <br> $\mathrm{ppm} / \mathrm{mA}$ <br> $\mathrm{ppm} / \mathrm{mA}$ |
| DROPOUT VOLTAGE | $\mathrm{V}_{\mathrm{s}}-\mathrm{V}_{\mathrm{o}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=4.6 \mathrm{~V}, \mathrm{I}_{\mathrm{LOAD}}=10 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{S}}=5.4 \mathrm{~V}, \mathrm{I}_{\mathrm{LOAD}}=30 \mathrm{~mA} \end{aligned}$ |  |  | $\begin{aligned} & 0.50 \\ & 1.30 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |
| LONG-TERM STABILITY | $\Delta \mathrm{V}_{\mathrm{o}}$ | 1000 Hours @ $+150^{\circ} \mathrm{C}$ |  | 2 |  | mV |
| NOISE VOLTAGE | $\mathrm{e}_{\mathrm{N}}$ | 0.1 Hz to 10 Hz |  | 50 |  | $\mu \mathrm{V}$ p-p |

ELECTRICAL CHARACTERISTICS (@ $V_{S}=+4.2 \mathrm{~V},-40^{\circ} \mathrm{C} \leq T_{A} \leq+85^{\circ} \mathrm{C}$ unless otherwise noted)

| Parameter | Symbol | Condition | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | $\mathrm{TCV}_{0}{ }^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{OUT}}=1 \mathrm{~mA}$ |  |  | $\begin{aligned} & 5 \\ & 10 \\ & 25 \\ & \hline \end{aligned}$ |  |
| LINE REGULATION <br> "E" Grade <br> " $F$ \& G" Grades <br> "E" Grade <br> "F \& G" Grades | $\begin{aligned} & \Delta \mathrm{V}_{\mathrm{O}} \Delta \mathrm{~V}_{\text {IN }} \\ & \Delta \mathrm{V}_{\mathrm{O}} \Delta \mathrm{I}_{\mathrm{LOA}} \end{aligned}$ | $\begin{aligned} & 4.2 \mathrm{~V} \leq \mathrm{V}_{S} \leq 15 \mathrm{~V}, \mathrm{I}_{\mathrm{OUT}}=1 \mathrm{~mA} \\ & \mathrm{~V}_{s}=5.4 \mathrm{~V}, 0 \leq \operatorname{lout} \leq 25 \mathrm{~mA} \end{aligned}$ |  | $\begin{aligned} & 2 \\ & 4 \\ & 2 \\ & 4 \\ & \hline \end{aligned}$ | $\begin{array}{r} 4 \\ 8 \\ 4 \\ 8 \\ \hline \end{array}$ | ppm/V <br> ppm/V <br> $\mathrm{ppm} / \mathrm{mA}$ <br> $\mathrm{ppm} / \mathrm{mA}$ |
| DROPOUT VOLTAGE | $\mathrm{V}_{\mathrm{s}}-\mathrm{V}_{\mathrm{o}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=4.6 \mathrm{~V}, \mathrm{I}_{\mathrm{LOAD}}=10 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{S}}=5.4 \mathrm{~V}, \mathrm{I}_{\mathrm{LOAD}}=30 \mathrm{~mA} \end{aligned}$ |  |  | $\begin{aligned} & 0.50 \\ & 1.30 \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |

ELECTRICAL CHARACTERISTICS (@ $V_{S}=+4.2 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ unless otherwise noted)

| Parameter | Symbol | Condition | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TEMPERATURE COEFFICIENT <br> "E" Grade <br> "F" Grade <br> "G" Grade | $\mathrm{TCV}_{\mathrm{O}}{ }^{\circ} \mathrm{C}$ |  |  |  | $\begin{aligned} & 7 \\ & 15 \\ & 25 \end{aligned}$ | $\begin{aligned} & \mathrm{ppm} /{ }^{\circ} \mathrm{C} \\ & \mathrm{ppm} /{ }^{\circ} \mathrm{C} \\ & \mathrm{ppm} /{ }^{\circ} \mathrm{C} \\ & \hline \end{aligned}$ |
| LINE REGULATION <br> "E" Grade <br> "F \& G" Grades <br> "E" Grade <br> "F \& G" Grades | $\begin{aligned} & \Delta \mathrm{V}_{\mathrm{O}} / \Delta \mathrm{V}_{\mathrm{IN}} \\ & \Delta \mathrm{~V}_{\mathrm{O}} / \Delta \mathrm{I}_{\mathrm{LOAD}} \end{aligned}$ | $\begin{aligned} & 4.2 \mathrm{~V} \leq \mathrm{V}_{\mathrm{S}} \leq 15 \mathrm{~V}, \mathrm{I}_{\mathrm{OUT}}=1 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{S}}=5.0 \mathrm{~V}, 0 \leq \mathrm{I}_{\mathrm{OUT}} \leq 20 \mathrm{~mA} \end{aligned}$ |  | $\begin{aligned} & 2 \\ & 4 \\ & 2 \\ & 4 \\ & \hline \end{aligned}$ | $\begin{aligned} & 4 \\ & 8 \\ & 4 \\ & 8 \\ & \hline \end{aligned}$ | ppm/V <br> $\mathrm{ppm} / \mathrm{V}$ <br> $\mathrm{ppm} / \mathrm{mA}$ <br> $\mathrm{ppm} / \mathrm{mA}$ |
| DROPOUT VOLTAGE | $\mathrm{V}_{\mathrm{s}}-\mathrm{V}_{\mathrm{o}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=4.7 \mathrm{~V}, \mathrm{I}_{\mathrm{LOAD}}=10 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{S}}=5.6 \mathrm{~V}, \mathrm{I}_{\mathrm{LOAD}}=30 \mathrm{~mA} \end{aligned}$ |  |  | $\begin{array}{r} 0.60 \\ 1.50 \\ \hline \end{array}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \hline \end{aligned}$ |
| SHUTDOWN PIN Logic High Input Voltage Logic High Input Current Logic Low Input Voltage Logic Low Input Current | $\begin{aligned} & \mathrm{V}_{\mathrm{H}} \\ & \mathrm{I}_{\mathrm{L}} \\ & \mathrm{~V}_{\mathrm{L}} \\ & \mathrm{I}_{\mathrm{L}} \\ & \hline \end{aligned}$ | $\mathrm{V}_{\mathrm{S}}=4.5 \mathrm{~V}$ | 2.4 |  | $\begin{aligned} & -5 \\ & 0.8 \\ & -5 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mu \mathrm{~A} \\ & \mathrm{~V} \\ & \mu \mathrm{~A} \\ & \hline \end{aligned}$ |
| SUPPLY CURRENT Sleep Mode |  | $\mathrm{V}_{\mathrm{S}}=4.5 \mathrm{~V}$ |  |  | $\begin{array}{r} 45 \\ 15 \\ \hline \end{array}$ | $\begin{aligned} & \mu \mathrm{A} \\ & \mu \mathrm{~A} \end{aligned}$ |

[^121]This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

## REF19x Series

WAFER TEST LIMITS (@ $\mathrm{I}_{\text {la00 }}=0 \mathrm{~mA}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)

| Parameter | Symbol | Condition | Limits | Units |
| :---: | :---: | :---: | :---: | :---: |
| Initial Accuracy REF190 REF191 REF192 REF193 REF194 REF195 REF196 REF198 | $\mathrm{V}_{0}$ |  | Adjustable $2.043 / 2.053$ $2.495 / 2.505$ $2.990 / 3.010$ $4.495 / 4.505$ $4.995 / 5.005$ $3.290 / 3.310$ $4.091 / 4.101$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \end{aligned}$ |
| LINE REGULATION | $\Delta \mathrm{V}_{\mathrm{O}} / \Delta \mathrm{V}_{\text {IN }}$ | $\mathrm{V}_{\mathrm{O}}+1.3 \mathrm{~V}<\mathrm{V}_{\text {IN }}<15 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=30 \mathrm{~mA}$ |  | $\mathrm{mV} / \mathrm{V}$ |
| LOAD REGULATION | $\Delta \mathrm{V}_{\mathrm{O}} / \Delta \mathrm{I}_{\text {LOAD }}$ | $1 \mathrm{~mA}<\mathrm{I}_{\text {LOAD }}<30 \mathrm{~mA}, \mathrm{~V}_{\text {IN }}=\mathrm{V}_{\mathrm{O}}+1.3 \mathrm{~V}$ |  | $\mathrm{mV} / \mathrm{mA}$ |
| DROPOUT VOLTAGE | $\mathrm{V}_{\mathrm{O}}-\mathrm{V}+$ | $\begin{aligned} & \mathrm{I}_{\text {LOAD }}=10 \mathrm{~mA} \\ & \mathrm{I}_{\text {LOAD }}=30 \mathrm{~mA} \end{aligned}$ | $\begin{aligned} & 0.5 \\ & 1.3 \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |
| STANDBY MODE INPUT <br> Logic Input High Logic Input Low | $\begin{aligned} & \mathrm{V}_{\mathrm{IH}} \\ & \mathrm{~V}_{\mathrm{IL}} \end{aligned}$ |  | $\begin{aligned} & 2.4 \\ & 0.8 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |
| SUPPLY CURRENT <br> Standby Mode |  | No Load | $\begin{array}{r} 45 \\ \quad 15 \\ \hline \end{array}$ | $\begin{aligned} & \mu \mathrm{A} \\ & \mu \mathrm{~A} \end{aligned}$ |

NOTE
For proper operation, a $1 \pi \mu \mathrm{~F}$ capacitor is required between the output pins and the GND pin of the REF19x. Electrical tests and wafer probe to the limits shown. Due to variations in assembly methods and normal yield loss, yield after packaging is not guatanteed for standard product dice. Consult factory to negotiate specifications based on dice lot qualifications through sample lot assembly and resting.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

| Supply Voltage |  |
| :---: | :---: |
| Output Short-Circuit Duration | Indefinite |
| Storage Temperature Range |  |
| P, S Packages | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Operating Temperature Range |  |
| REF19x | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Junction Temperature Range |  |
| P, S Packages | $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Lead Temperature Range (Sol | $+300^{\circ} \mathrm{C}$ |

ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| REF19xGP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | N-8 <br> REF19xGS |
| REF19xGBC | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin SOIC <br> $+25^{\circ} \mathrm{C}$ | SO-8 |

*For outline information see Package Information section.

| Package Type | $\theta_{\mathrm{JA}}{ }^{2}$ | $\theta_{\mathrm{JC}}$ | Units |
| :--- | :--- | :--- | :--- |
| 8-Pin Plastic DIP (P) | 103 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin SOIC (S) | 158 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTES

${ }^{1}$ Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
${ }^{2} \theta_{\mathrm{JA}}$ is specified for the worst case conditions, i.e., $\theta_{\mathrm{JA}}$ is specified for device in socket for P-DIP, and $\theta_{\mathrm{JA}}$ is specified for device soldered in circuit board for SOIC package.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although these devices feature proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.
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OP42 - High Speed, Fast Settling Precision Operational Amplifier ..... 9-365
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OP221 - Dual Low Power Operational Amplifier Single or Dual Supply ..... 9-439
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## Selection Trees — Operational Amplifiers







Selection Trees - Operational Amplifiers


## Single Supply Amplifiers

| Model | ISY <br> max <br> mA | $\mathbf{V}_{\text {os }}$ max mV | Supply Voltage Range $\mathbf{V}$ | $\begin{aligned} & \text { GBW } \\ & \text { typ } \\ & \text { MHz } \end{aligned}$ | $\begin{aligned} & \text { SR } \\ & \text { typ } \\ & \mathbf{V} / \boldsymbol{\mu s} \end{aligned}$ | Package Options ${ }^{1}$ | Temp Ranges ${ }^{2}$ | Comments | Page ${ }^{3}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| OP22 | 0.0002-0.4 | 0.3-1 | +3 to +30 | 0.25 | 0.08 | H, N, Q, R | I, M/ | Programmable | A 2-597 |
| OP90 | 0.02 | 0.15-0.45 | +1.6 to +36 | 0.02 | - | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/s | Micropower, Low Voltage | 9-375 |
| OP290 | 0.04 | 0.2-0.5 | +1.6 to +36 | 0.02 | - | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/ ${ }_{\text {DS }}$ | Dual Micropower, Low Voltage | 9-477 |
| OP20 | 0.08 | 0.25-1 | +5 to +30 | 0.1 | 0.05 | E, N, Q, R | I, M/ | Micropower, Low Cost | A 2-585 |
| OP490 | 0.08 | 0.5-1 | +1.6 to +36 | 0.02 | - | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/Ds | Quad Micropower, Low Voltage | 9-564 |
| OP220 | 0.17 | 0.15-0.75 | +5 to +30 | 0.2 | 0.05 | $\mathbf{H}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/s | Dual Micropower, Low Cost | 9-436 |
| OP295 | 0.200 | 0.25-1.0 | +2.4 to +36 | 0.08 | 0.02 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | Rail-to-Rail Dual | 9-518 |
| OP80 | 0.325 | 1.5 | +5 to +16 | 0.3 | 0.4 | N, Q, H | I, M | Low $\mathrm{I}_{\mathrm{B}}$, CMOS | A 2-727 |
| OP291/491 | 0.350 | 0.7 | +2.7 to +12 | 3 | 0.5 | N, R | I | Rail-to-Rail, Micropower | 9-481 |
| OP420 | 0.36 | 2.5-6 | +5 to +30 | 0.15 | 0.05 | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/s | Quad Micropower, Low Cost | 9-538 |
| OP21 | 0.3-0.4 | 0.1-0.5 | +5 to +30 | 0.6 | 0.25 H , | N, Q, R | I, M/ | Low Cost, Low Power | A 2-591 |
| OP495 | 0.4 | 0.2-0.5 | +3 to +36 | 0.08 | 0.02 | N, Q, R | I, M | Quad Rail to Rail | 9-518 |
| AD820 | 0.660 | 0.25-1 | +4 to +36 | 2 | 3.75 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M | Fast FET Input Rail to Rail | 9-170 |
| OP221 | 0.8 | 0.15-0.5 | +5 to +30 | 0.6 | 0.3 | $\mathbf{H}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/s | Dual Low Cost, Low Power | 9-439 |
| AD822 | 1.3 | 0.25-1 | +4 to +36 | 2 | 3.75 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M | Dual AD820 | 9-170 |
| OP183/283 | 1.5 | 1.0 | +3 to +18 | 5 | 10 | N, R | I | 5 MHz , Low Noise | 9-420 |
| OP421 | 1.8 | 2.5-6 | +5 to +30 | 1.9 | 0.5 | N, Q, R | I, M/D | Quad Low Cost, Low Power | A 2-993 |
| OP279 | 2.5 | 4.0 | +4.75 to +12 | 2 | 5 | N, R | I | Rail-to-Rail Input/Output, 50 mA Out | 9-459 |
| AD812 | 3.5 | 3.0 | +3.0 to +15 | 50 | 125 | N, R | I | Dual 50 MHz , Current Feedback | 9-110 |
| AD813 | 3.5 | 3.0 | +3.0 to +15 | 50 | 100 | N, R | I | Triple Current Feedback Videe Op Amp | 9-127 |
| OP113/213/413 | 4 | 0.150 | +5 to +30 | 3 | 1 | $\mathbf{E}, \mathbf{N}, \mathbf{P}, \mathbf{Q}, \mathbf{R}$ | I, M | Low Noise, Low Drift Op Amp | 9-382 |




 temperature designator will be followed by: / to indicate $883 \mathrm{~B}, \mathrm{~J}$ for JAN, ${ }_{\mathrm{D}}$ for SMD, and ${ }_{\mathrm{s}}$ for space level.
${ }^{3} \mathrm{~A}=$ Amplifier Reference Manual. All other entries refer to this volume.
Boldface Type: Data sheet information in this volume.

Selection Guides—Operational Amplifiers
High Speed Amplifiers

| Model | SR <br> $\mathbf{V} / \boldsymbol{\mu} \mathbf{s}$ <br> typ | GBW <br> MHz <br> typ | Settling Time ns to \% typ | $\mathbf{A}_{\mathbf{C L}}$ min V/V | $\begin{aligned} & \mathbf{V}_{\mathrm{Os}} \\ & \mathrm{mV} \\ & \text { typ } \end{aligned}$ | $\mathbf{I}_{\text {OUT }}$ <br> mA. <br> min | Supply <br> Current <br> mA <br> typ | Package Options ${ }^{1}$ | Temp Ranges ${ }^{2}$ | Comments | Page ${ }^{3}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| AD8004 | 3000 | 400 | 10-0.1 | 1 | 5.0 | 50 | 3.5 | N, $\mathbf{R}$ | I | Quad Very High Slew Rate Amplifier | 9-291 |
| AD811 | 2500 | 1000 | 65-0.01 | 1 | 0.5 | 100 typ | 16.5 | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | Video Amp, 0.12\%/0.01 ${ }^{\circ}$ Differential Gain/Phase Error, 0.1 dB Flatness to 35 MHz | 9-107 |
| AD9624 | 2200 | 1800 | 14-0.01 | 6 | 2 | 60 | 23 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | Voltage Feedback Amp; $\pm 3 \mathrm{~V}$ Supply Operation | 9-318 |
| AD9623 | 2100 | 1080 | 14-0.01 | 4 | 2 | 60 | 23 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | Voltage Feedback Amp; -64 dB HD @ 20 MHz | 9-315 |
| AD844 | 2000 | 900 | 100-0.1 | 1 | 0.05 | 20 | 6.5 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/s | Constant 10 ns Rise Time for Any Pulse Input, Current Feedback | 9-245 |
| AD9618 | 1800 | 8000 | 10-0.1 | -1 | 0.2 | 60 | 31 | N, Q, R, $\mathbf{Z}$ | C, $\mathbf{I}, \mathrm{M} /{ }_{\mathbf{D}}$ | Low Distortion, Wideband, IMD $\leq-70 \mathbf{~ d B c}$ at $20 \mathbf{M H z}$ | 9-303 |
| AD9617 | 1600 | 570 | 10-0.1 | 1 | 0.4 | 60 | 34 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}, \mathbf{Z}$ | C, $\mathbf{I}, \mathrm{M} /{ }_{\text {DS }}$ | Low Distortion, Wide Bandwidth, IMD $\leq \mathbf{- 7 0} \mathbf{~ d B c}$ at $20 \mathbf{M H z}$ | 9-300 |
| AD8036 | 1600 | 350 | 16-0.01 | 1 | 2 | 70 typ | 17 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | Clamping, Voltage Feedback, $\pm 3 \mathrm{~V}$ Supply | 9-295 |
| AD8037 | 1600 | 240 | 16-0.01 | 2 | 2 | 70 typ | 17 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | Clamping, Voltage Feedback, $\pm 3 \mathrm{~V}$ Supply | 9-295 |
| AD812 | 1600 | 145 | 50-0.1 | 1 | 2 | 40 | 3.5 | N, R | I | Low Power, Single Supply, Dual | 9-110 |
| AD9622 | 1500 | 440 | 14-0.01 | 2 | 2 | 60 | 23 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | Voltage Feedback Amp; -66 dB HD @ 20 MHz | 9-312 |
| AD9632 | 1500 | 250 | 11-0.1 | 2 | 2 | 70 typ | 17 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | Low Distortion, Voltage Feedback, $\pm 3$ V Supply | 9-324 |
| AD9631 | 1300 | 320 | 11-0.1 | 1 | 2 | 70 typ | 17 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | Low Distortion, Voltage Feedback, $\pm 3$ V Supply | 9-324 |
| AD8001 | 1200 | 880 | 10-0.1 | 1 | 2.0 | 50 | 5 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I | Current Feedback, Low Power, 880 MHz | 9-265 |
| AD8002 | 1200 | 880 | 10-0.1 | 1 | 2.0 | 50 | 5 | N, R | I | Dual AD8001 | 9-278 |
| AD9621 | 1200 | 350 | 11-0.01 | 1 | 2 | 60 | 23 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | Voltage Feedback Amp; Wide BW; Low Noise | 9-309 |
| AD810 | 1000 | 650 | 50-0.1 | 1 | 1.5 | 40 | 6.8/2.5 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | Video Amp with Disable Feature | 9-92 |
| OP260 | 1000 | 90 | 250-0.1 | 1 | 1 | 20 | 9 | E, H, N, Q, R, | I, M/ ${ }_{\text {DS }}$ | Dual Current Feedback | A 2-873 |
| AD5539 | 600 | 1400 | 12-1.0 | 5 | 2.0 | 15 | 14 | $\mathbf{N}, \mathbf{Q}$ | C, M | General Purpose, High Speed Amp | 9-262 |
| AD830 | 530 | 100 | 25-0.1 | 1 | 1.5 | 50 | 14.5 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M | Video Difference Amplifier | 9-218 |
| ADEL2020 | 500 | 300 | 60-0.1 | 1 | 1.5 | 30 | 6.8/2.1 | N, R | I | Second Source to EL2020 | 9-329 |
| AD818 | 500 | 260 | 80-0.01 | -1 | 0.5 | 50 | 7 | N, R | I | Low Power, Video Amp | 9-158 |
| AD828 | 500 | 260 | 80-0.01 | -1 | 0.5 | 50 | 7 | N, R | I | Dual AD818 | 9-203 |
| AD846 | 450 | 450 | 110-0.01 | 1 | 0.025 | 20 typ | 5 | $\mathbf{N}, \mathbf{Q}$ | I, M/ ${ }_{\text {DS }}$ | High Speed, Precision, Current Feedback | 9-251 |
| AD813 | 450 | 100 | 50-0.1 | 1 | 2 | 30 | 3.5 | N, R | I | Triple Low Power Video Amp | 9-127 |
| AD840 | 400 | 400 | 100-0.01 | 10 | 0.1 | 50 | 10.5 | $\mathbf{E}, \mathbf{N}, \mathbf{Q}$ | C, $M /{ }_{\text {DS }}$ | Wide Bandwidth Precision, Fast Settling, $\mathbf{A}_{\text {vcL }} \geq 10$ | 9-233 |
| AD842 | 375 | 80 | 100-0.01 | 2 | 0.3 | 100 | 13 | $\mathbf{E}, \mathbf{H}, \mathbf{N}, \mathbf{Q}$ | C, $M / \mathbf{D}$ | Fast Settling, High Current Output, Cable Driver, $\mathbf{A}_{\text {vcl }} \geq 2$ | 9-239 |
| AD817 | 350 | 50 | 70-0.01 | 1 | 0.5 | 50 | 7 | N, R | I | Low Power, General Purpose, High $\mathbf{I}_{\text {Out }}$ | 9-145 |
| AD826 | 350 | 50 | 70-0.01 | 1 | 0.5 | 50 | 7 | N, R | I | Dual AD817 | 9-187 |
| AD849 | 300 | 725 | 80-0.1 | 25 | 0.3 | 20 typ | 5.1 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M/ | High Speed, Low Power Preamp, Drives Capacitive Loads | 9-258 |


| Model | SR <br> V／us <br> typ | GBW <br> $\mathbf{M H z}$ <br> typ | Settling Time ns to \％ typ | $\begin{aligned} & \mathbf{A}_{\mathbf{C L}} \\ & \min \\ & \mathbf{V} / \mathbf{V} \end{aligned}$ | $\begin{aligned} & \mathbf{V}_{\mathbf{o s}} \\ & \mathbf{m V} \\ & \text { typ } \end{aligned}$ | $\mathbf{I}_{\text {out }}$ mA min | Supply Current mA typ | Package Options ${ }^{1}$ | Temp Ranges ${ }^{2}$ | Comments | Page ${ }^{3}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| AD848 | 300 | 175 | 100－0．1 | 5 | 0.2 | 20 typ | 5.1 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C，I，M／ | High Speed，Low Power， Drives Capacitive Loads | 9－258 |
| AD827 | 300 | 50 | 120－0．1 | 1 | 0.5 | 20 typ | 10.5 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C， $\mathrm{I}, \mathrm{M} / \mathrm{D}$ | Dual AD847 | 9－200 |
| AD847 | 300 | 50 | 120－0．01 | 1 | 0.5 | 20 typ | 5.3 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C，I，M／ $\mathrm{DS}^{\text {d }}$ | High Speed，Low Power， Drives Capacitive Loads | 9－254 |
| AD841 | 300 | $40^{4}$ | 110－0．01 | 1 | 0.5 | 50 | 11 | E，H，N，Q | C， $\mathrm{M}_{\text {／}}$（ | High Speed，Precision， Drives Capacitive Loads | 9－236 |
| AD843 | 250 | $34^{4}$ | 135－0．01 | 1 | 0.5 | 50 | 12 | $\mathbf{E}, \mathbf{H}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | $\mathrm{C}, \mathrm{I}, \mathrm{M} / \mathrm{Ds}^{\text {d }}$ | FET Input，Fast Settling，High Speed | 9－242 |
| AD829 | 230 | 750 | 65－0．1 | 1 | 0.2 | 20 typ | 5.3 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C，I，M | High Speed，Low Noise，Video Amp | 9－215 |
| OP467 | 170 | 30 | 170－0．01 | 1 | 0.5 | 10 | 8 | $\mathbf{N}, \mathbf{P}, \mathbf{Q}, \mathbf{R}$ | I，M | Quad High Speed | 9－541 |
| AD845 | 100 | $16^{4}$ | 350－0．01 | 1 | 0.1 | 25 typ | 10 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I，M／s | FET Input，Fast Settling，High Speed | 9－248 |

${ }^{1}$ Package Options：D＝Hermetic DIP，Ceramic or Metal；E＝Ceramic Leadless Chip Carrier；F＝Ceramic Flatpack；G＝Ceramic Pin Grid Array；H＝Hermetic Metal Can；J＝J－Leaded Ceramic Package； $M=$ Hermetic Metal Can DIP； $\mathrm{N}=$ Plastic or Epoxy Sealed DIP；P＝Plastic Leaded Chip Carrier； $\mathrm{Q}=$ Cerdip； $\mathrm{R}=$ Small Outline＂SOIC＂Package；RS＝SSOP－Shrink Small Outline Package；S＝Plastic Quad Flatpack；ST＝Thin Quad Flatpack； $\mathrm{T}=\mathrm{TO}-92 ; \mathrm{U}=\mathrm{TSOP}-$ Thin Small Outline Package； $\mathrm{W}=$ Nonhermetic Ceramic／Glass DIP； $\mathrm{Y}=$ Single－In－Line＂SIP＂Package； $\mathrm{Z}=$ Ceramic Leaded Chip Carrier． ${ }^{2}$ Temperature Ranges： $\mathrm{C}=$ Commercial， $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C} ; \mathrm{I}=$ Industrial，$-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$（Some older products $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ）； $\mathrm{M}=$ Military，$-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ ．If a device has military grade offerings，the M temperature designator will be followed by：／to indicate 883 B, ，for $\mathrm{JAN},{ }_{\mathrm{D}}$ for SMD ，and ${ }_{\mathrm{s}}$ for space level．
${ }^{3}$ A $=$ Amplifier Reference Manual．All other entries refer to this volume．
${ }^{4}-3 \mathrm{~dB}$ BW
Boldface Type：Data sheet information in this volume．

## Selection Guides-Operational Amplifiers

## Low Voltage Noise Amplifiers

| Model | Voltage <br> Noise <br> en <br> typ <br> 1 kHz <br> $\mathrm{nV} \sqrt{\mathrm{Hz}}$ | Voltage <br> Noise <br> en <br> typ <br> 10 kHz <br> $\mathrm{nV} \sqrt{\mathrm{Hz}}$ | Current <br> Noise <br> In $\pm \mathbf{I n}-$ <br> typ <br> 1 kHz <br> $\mathrm{pA} \sqrt{\mathrm{Hz}}$ | $\begin{aligned} & \mathbf{I}_{\mathbf{B}} \\ & \mathbf{t y p} \\ & \mathbf{n A} \end{aligned}$ | $\begin{aligned} & \mathbf{V}_{\mathbf{O s}} \\ & \mathbf{m V} \\ & \text { typ } \end{aligned}$ | $\begin{aligned} & \text { GBW } \\ & \text { MHz } \\ & \text { typ } \end{aligned}$ | SR <br> V/us typ | Settling <br> Time <br> ns to \% <br> typ | $\begin{aligned} & \mathbf{A}_{\mathbf{C L}} \\ & \min \\ & \mathbf{V} / \mathbf{V} \end{aligned}$ | Package Options ${ }^{1}$ | Temp Ranges ${ }^{2}$ | Comments | Page ${ }^{3}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| AD797 | 0.9 | 0.9 | 2 | 500 | 0.025 | 110 | 20 | - | 1 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | Ultralow Noise, Low Distortion | 9-78 |
| AD829 | 1.7 | 1.7 | 1.5 | 3300 | 0.2 | 750 | 230 | 65-0.1 | 1 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M | High Speed, Low Noise, Video Amp | 9-215 |
| AD811 | 1.9 | 1.9 | 1.5/20 | 2000 | 0.5 | 1000 | 2500 | 65-0.01 | 1 | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | High Performance Video Op Amp | 9-107 |
| AD9617 | 2.0 | 1.3 | 32/32 | 12000 | 0.5 | 570 | 1400 | 10-0.1 | $\pm 1$ | $\mathbf{N}, \mathbf{Q}, \mathrm{R}, \mathrm{Z}$ | C, $\mathbf{I}, \mathrm{M} /{ }_{\text {DS }}$ | Low Distortion, Wide Bandwidth | 9-300 |
| AD9618 | 2.0 | 1.3 | 32/32 | 10000 | 0.5 | 8000 | 1800 | 9-0.1 | +5, -1 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}, \mathbf{Z}$ | C, I, M/D | Low Distortion, Wide Bandwidth | 9-303 |
| AD844 | 2 | 2.0 | 12/10 | 200 | 0.05 | 900 | 2000 | 100-0.1 | 1 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/s | Current Feedback Amplifier | 9-245 |
| AD846 | 2 | 2.0 | 6/20 | 100 | 0.025 | 450 | 450 | 110-0.01 | 1 | N, Q | $\mathrm{I}, \mathrm{M} / \mathrm{DS}^{\text {d }}$ | Current Feedback, Precision | 9-251 |
| ADEL2020 | 2.9 | 2.9 | 1.5/13 | 1000 | 1.5 | 300 | 500 | 60-0.1 | I | N, $\mathbf{R}$ | , | EL2020 Second Source | 9-329 |
| AD810 | 2.9 | 2.9 | 1.5/13 | 2000 | 1.5 | 650 | 1000 | 125-0.01 | 1 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | Video Op Amp with Disable | 9-92 |
| AD849 | 3 | 3.0 | - | 3300 | 0.3 | 725 | 300 | 80-0.1 | 25 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M/ | High Speed, Low Power | 9-258 |
| OP27 | 3.0 | 3.0 | 0.4 | 10 | 0.01 | 8 | 2.8 | - | 1 | E, H, N, Q, R | $\mathbf{C , ~} \mathbf{I}, \mathbf{M} /{ }_{\text {Js }}$ | Low Noise, Precision | 9-357 |
| OP227 | 3 | 3.0 | 0.4 | 10 | 0.02 | 8 | 2.8 | - | 1 |  | C, I, M/bs | Dual Matched Precision | A 2-843 |
| OP37 | 3 | 3.0 | 0.4 | 10 | 0.01 | 63 | 17 | - | 1 | $\mathbf{E}, \mathbf{H}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, $\mathbf{I}, \mathrm{M} /{ }_{\text {DS }}$ | Fast, Precision $\mathrm{A}_{\mathbf{v C L}} \geq 5$ | 9-361 |
| AD745 | 3.2 | 2.9 | 0.007 | 0.150 | 0.1 | 20 | 12.5 | 5000-0.01 | 5 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M | Ultralow Noise, High Speed, BiFET Op Amp | 9-58 |
| AD743 | 3.2 | 2.9 | 0.007 | 0.15 | 0.1 | 4.5 | 2.8 | - | 1 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M | Ultralow Noise FET Input | 9-52 |
| OP270 | 3.2 | 3.2 | 0.6 | 5 | 0.01 | 5 | 2.4 | - | 1 | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | $\mathrm{I}, \mathrm{M} / \mathrm{ps}$ | Dual Monolithic | 9-447 |
| OP470 | 3.2 | 3.8 | 0.4 | 6 | 0.1 | 6 | 2 | - | 1 | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/ ${ }_{\text {DS }}$ | Quad Monolithic, Low Noise | 9-556 |
| AD9624 | 3.5 | 2.3 | 5.8 | 7000 | 2 | 1800 | 2200 | 14-0.01 | 6 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | $\mathbf{I}, \mathrm{M}$ | Low IMD at High Frequencies | 9-318 |
| AD812 | 3.5 | 3.5 | 1.5/18 | 20000 | 2.0 | 145 | 1600 | 50-0.1 | 1 | N, R | I | Dual, Single Supply, Current Feedback | 9-110 |
| AD813 | 3.5 | 3.5 | 1.5/18 | 30000 | 2.0 | 100 | 450 | 50-0.1 | 1 | N, R |  | Triple Video Amplifier | 9-127 |
| AD840 | 4 | - | - | 3500 | 0.1 | 400 | 400 | 100-0.01 | 10 | $\mathbf{E}, \mathbf{N}, \mathbf{Q}$ | C, M/ ${ }_{\text {DS }}$ | Wide Bandwidth, Precision | 9-233 |
| AD9623 | 4.2 | 2.6 | 8 | 6000 | 2 | 1080 | 2100 | 14-0.01 | 4 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | Balanced High Impedance Inputs | 9-315 |
| OP113/213/413 | 4.7 | 4.7 | 0.4 | 600 | 0.1 | 3.4 | 1.2 | 9000-0.01 | 1 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I | Single Supply-Single, Dual, Quad | 9-382 |
| OP467 | 6 | 5.5 | - | 100 | 1 | 30 | 170 | 170 | 1 | $\mathbf{N}, \mathbf{P}, \mathbf{Q}, \mathbf{R}$ | C, I, M | Quad, High Speed | 9-541 |
| OP275 | 6 | 6 | - | - | 1 | 9 | 22 | - | 1 | N, R | I, M | Dual Audio Amp | 9-454 |
| AD848 | 5 | - | - | 3300 | 0.2 | 175 | 300 | 100-0.1 | 5 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M/ | High Speed, Low Power | 9-258 |
| AD9622 | 5.5 | 3.8 | 12 | 7000 | 2 | 450 | 1500 | 14-0.01 | 2 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | Fast Pulse Response; Wide BW | 9-312 |
| OP176 | 6.0 | 6.0 | 0.5 | 175 | 1.0 | 10 | 25 | 1000-0.01 | 1 | N, R | I | Bipolar/JFET Audio Op Amp | 9-397 |
| OP471 | 6.5 | 6.5 | 0.4 | 7 | 0.25 | 6.5 | 8 | - | , | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, $M /{ }_{\text {DS }}$ | Quad Monolithic, Fast | 9-560 |
| AD9621 | 6.6 | 5.5 | 8.2 | 7000 | 2 | 350 | 1200 | 11-0.01 | 1 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | Fast Pulse Response; Wide BW | 9-309 |
| AD795 | 11 | 9 | 0.0006 | 0.001 | 0.1 | 2 | 1 | 11,000-0.01 | 1 | N, R | C | Low Power, Low Noise Photo Diode Preamp | 9-64 |
| OP271 | 7.6 | 7.6 | 0.6 | 4 | 0.075 | 5 | 8.5 | - | 1 | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/Ds | Dual Monolithic, Fast | 9-451 |
| AD645 | 9 | 8 | 0.0006 | 0.0007 | 0.1 | 2 | 2 | - | 1 | H, N | C, I, M | FET Input, Low IB, OPA111 Second Source | 9-34 |

[^122] $M=$ Hermetic Metal Can DIP; $\mathrm{N}=$ Plastic or Epoxy Sealed DIP; $\mathrm{P}=$ Plastic Leaded Chip Carrier; $\mathrm{Q}=$ Cerdip; $\mathrm{R}=$ Small Outline "SOIC" Package; RS = SSOP-Shrink Small Outline Package; $\mathrm{S}=$ Plastic Quad Flatpack; ST = Thin Quad Flatpack; T = TO-92; U = TSOP-Thin Small Outline Package; $\mathbb{W}=$ Nonhermetic Ceramic/Glass DIP; Y $=$ Single-In-Line "SIP" Package; Z $=$ Ceramic Leaded Chip Carrier. ${ }^{2}$ Temperature Ranges: $\mathrm{C}=$ Commercial, $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$; $\mathrm{I}=$ Industrial, $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ (Some older products $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ); $\mathrm{M}=$ Military,$-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. If a device has military grade offerings, the M temperature designator will be followed by: / to indicate 883B, , for JAN, ${ }_{\mathrm{D}}$ for SMD, and ${ }_{\mathrm{s}}$ for space level.
${ }^{3}$ A = Amplifier Reference Manual. All other entries refer to this volume.
Boldface Type: Data sheet information in this volume.

## Low Current Noise, Low Input Bias Current Amplifiers

| Model | $\mathbf{I}_{\mathrm{B}}$ pA $\max$ | $\begin{aligned} & \mathbf{I}_{\mathbf{N}} \\ & \mathbf{f = 1 \mathrm { kHz }} \\ & \mathbf{f}_{\mathbf{A}} / \sqrt{\mathbf{H z}} \end{aligned}$ | Input Differential | pedance <br> mmon Mode <br> p <br> p | CMRR <br> dB $\mathrm{f}=1 \mathrm{kHz}$ <br> typ | $V_{\text {os }}$ mV <br> max | $V_{\text {os }}$ TC $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ max | BW <br> MHz <br> $\operatorname{typ}^{1}$ | Package Options ${ }^{2}$ | Temp Ranges ${ }^{3}$ | Comments | Page ${ }^{4}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| AD549 | 0.06-0.25 | 0.11 | $10^{13}{ }^{1} 1$ | $10^{15} \mid 0.8$ | 62 | 0.25-1 | 5-20 | 1 | H | C, M/ | Monolithic, Lowest $\mathrm{I}_{\mathrm{B}}$ | 9-28 |
| AD515A | 0.075-0.3 | - | $10^{13} \mid 1.6$ | $10^{15} \mid 0.8$ | 62 | 1-3 | 15-50 | 1 | H | C | Lower Cost AD515 Replacement | A $2-45$ |
| OP80 | 0.25-1 | - | - |  | 90 | 1.5 | - | 0.3 | N, R, H | I, M | Low Cost CMOS | A 2-727 |
| AD546 | 0.5-1 | 0.4 | $10^{13} \mid 1$ | $10^{15} \mid 0.8$ | 90 | 1-2 | 20 | 1 | N | C | Low Cost 1 pA Amplifier | 9-22 |
| AD545A | 1-2 | - | $10^{13} \mid 1.6$ | $10^{15} \mid 0.8$ | 62 | 0.25-1 | 3-25 | 1 | H | C | Lower Cost AD545 Replacement | A 2-65 |
| AD795 | 1-3 | 0.6 | $10^{12}\| \| 2$ | $10^{14} \mid 2.2$ | 110 | 0.25-0.5 | 10 | 2 | N, R | C | Low Power, Low Noise, Photodiode Preamp | 9-64 |
| AD645 | 1.5-3 | 0.6 | $10^{13} \mid 1$ | $10^{14} \mid 3$ | 94 | 0.25-0.5 | 1-5 | 2 | N, H | C, I, M | Low Noise, Precision BiFET, (OPA111 Second Source) | 9-34 |
| OP41 | 5-20 | - | - |  | 98 | 0.25-2 | 5-10 | 0.5 | N, R, H | C, I, M/ | High Stability JFET | A 2-645 |
| AD548 | 10-20 | 1.8 | $10^{12} \mid 3$ | $3 \times 10^{12}\| \| 3$ | 84 | 0.25-2 | 2-20 | 1 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}, \mathbf{H}$ | C, I, M/ | Low Power, Low Cost | 9-25 |
| AD648 | 10-20 | 1.8 | $10^{12}\| \| 3$ | $3^{12} \mid 3$ | 84 | 0.3-2 | 3-20 | 1 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}, \mathbf{H}$ | C, I, M/ | Dual AD548 | 9-37 |
| AD820 | 20-30 | 1.8 | - | - | 100 | 0.25-1 | 5-10 | 2 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M | Single Supply, Fast, Rail-to-Rail | 9-170 |
| AD822 | 20-30 | 1.8 | - | - | 100 | 0.25-1 | 5-10 | 2 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M | Dual AD820 | 9-170 |
| AD542 | 25-50 | - | - | - | 80 | 0.5-2 | 5-20 | 1 | H | C, M | Precision | 9-19 |
| AD544 | 25-50 | - | - | - | 80 | 0.5-2 | 5-20 | 2 | H | C, M | Precision, Low Distortion | 9-19 |
| AD711 | 25-50 | 10 | $3 \times 10^{12} \mid 5.5$ | $3 \times 10^{12} \mid 5.5$ | 62 | 0.25-2 | 3-20 | 4 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}, \mathbf{H}$ | C, I, M/ | Low Cost BiFET, Excellent AC and DC Performance | 9-47 |
| AD642 | 35-75 | - | $10^{12}\| \| 6$ | $10^{12}\| \| 6$ | 90 | 0.5-2 | - | 1 | H | C, M/ | Dual Precision | 9-31 |
| PM156A | 50 | 10 | - |  | 90 | 2 | 5 | 4.5 | Q, H | C, ${\mathrm{M} /{ }_{\text {JS }} \text { }}^{\text {d }}$ | Improved Industry Standard | A 2-1065 |
| PM157A | 50 | 10 | - |  | 90 | 2 | 5 | 20 | Q, H | C, $\mathrm{M} / \mathrm{DS}$ | Improved Industry Standard | A 2-1065 |
| AD712 | 50-75 | 10 | $3^{12} \mid$ \|5.5 | $3^{12} \mid$ \|5.5 | 94 | 0.3-3 | 5-20 | 4 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}, \mathbf{H}$ | C, I, M/ | Dual AD711 | 9-47 |
| AD744 | 50-100 | 10 | $3 \times 10^{12} \mid 5.5$ | $3 \times 10^{12} \mid 5.5$ | 88 | 0.25-1 | 3-20 | 13 | $\mathbf{H}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M | Fast Settling BiFET | 9-55 |
| OP15 | 50-200 | 10 | - |  | 90 | 0.5-3 | 5-15 | 6 | N, Q, R, H | C, I, M/ ${ }_{\text {ds }}$ | Precision BiFET | A 2-571 |
| OP16 | 50-200 | 10 | - |  | 90 | 0.5-3 | 5-15 | 8 | N, Q, R, H | C, $\mathrm{I}, \mathrm{M} / \mathrm{DS}$ | Precision BiFET | A 2-571 |
| OP17 | 50-200 | 10 | - |  | 90 | 0.5-3 | 5-15 | 30 | N, Q, R, H | C, $\mathrm{I}, \mathrm{M} / \mathrm{DS}$ | Fast, Precision BiFET | A 2-571 |
| OP42 | 200-250 | 7 | $10^{12}\| \| 6$ |  | 98 | 0.75-5 | 10 | 10 | E, H, N, R, Q | $\mathbf{I}, \mathbf{M}$ | Fast, Precision BiFET | 9-365 |

${ }^{1}$ Unity gain small signal bandwidth.
${ }^{2}$ Package Options: D = Hermetic DIP, Ceramic or Metal; E = Ceramic Leadless Chip Carrier; F = Ceramic Flatpack; G = Ceramic Pin Grid Array; H = Hermetic Metal Can; J = J-Leaded Ceramic Package; M = Hermetic Metal Can DIP; N = Plastic or Epoxy Sealed DIP; P = Plastic Leaded Chip Carrier; Q = Cerdip; R = Small Outline "SOIC" Package; RS = SSOP-Shrink Small Outline Package; S = Plastic Quad Flatpack; ST = Thin Quad Flatpack; $\mathrm{T}=\mathrm{TO}-92 ; \mathrm{U}=\mathrm{TSOP}-$ Thin Small Outline Package; $\mathrm{W}=$ Nonhermetic Ceramic/Glass DIP; $\mathrm{Y}=$ Single-In-Line "SIP" Package; $\mathrm{Z}=$ Ceramic Leaded Chip Carrier. ${ }^{3}$ Temperature Ranges: $\mathrm{C}=$ Commercial, $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C} ; \mathrm{I}=$ Industrial, $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ (Some older products $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ); $\mathrm{M}=$ Military, $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. If a device has military grade offerings, the M temperature designator will be followed by: / to indicate 883B, ${ }_{\mathrm{J}}$ for JAN, ${ }_{\mathrm{D}}$ for SMD, and ${ }_{\mathrm{s}}$ for space level.
${ }^{4}$ A $=$ Amplifier Reference Manual. All other entries refer to this volume.
Boldface Type: Data sheet information in this volume.

## Selection Guides-Operational Amplifiers

## Precision Amplifiers

| Model | $V_{\text {os }}$ $\mu \mathrm{V}$ max | $\begin{aligned} & \mathbf{V}_{\text {os }} \mathrm{TC} \\ & \mu \mathrm{~V} /{ }^{\circ} \mathrm{C} \\ & \max \end{aligned}$ | Noise <br> $\mu \mathrm{V}$ p-p <br> $0.1-10 \mathrm{~Hz}$ <br> typ | $\begin{aligned} & \text { GBW } \\ & \text { MHz } \\ & \text { typ } \end{aligned}$ | Slew <br> Rate <br> V/us <br> typ | $\mathrm{I}_{\mathrm{B}}$ nA max | CMRR <br> dB $\mathrm{f}=1 \mathrm{kHz}$ <br> typ | Package Options ${ }^{1}$ | Temp Ranges ${ }^{2}$ | Comments | Page ${ }^{3}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| OP177 | 10-60 | 0.1-1.2 | 0.35 | 0.6 | 0.3 | 1.5-2.8 | 110 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/ | Highest Precision | 9-415 |
| AD707 | 15-90 | 0.1-1.0 | 0.23 | 0.9 | 0.3 | 1.0-2.5 | 100 | $\mathbf{H}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M/ | High Precision | 9-44 |
| OP77 | 25-100 | 0.3-1.2 | 0.35 | 0.6 | 0.3 | 2-2.8 | 105 | $\mathbf{E}, \mathbf{H}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M/ ${ }_{\text {ds }}$ | Next Generation OP07 | 9-370 |
| AD705 | 25-90 | 0.6-1.2 | 0.5 | 0.8 | 0.15 | 0.1-0.15 | 110 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M | Low $\mathrm{I}_{\mathrm{B}}$ Precision Bipolar | 9-40 |
| OP97 | 25-75 | 0.6-2 | 0.5 | 0.9 | 0.2 | 0.1-0.15 | 100 | $\mathbf{E}, \mathbf{H}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | $\mathrm{I}, \mathrm{M} / \mathrm{DS}$ | Low Power OP07 | 9-379 |
| OP27 | 25-100 | 0.6-1.8 | 0.08 | 8 | 2.8 | 40-80 | 125 | $\mathbf{E}, \mathbf{H}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M/Js | Low Noise, Precision | 9-357 |
| OP37 | 25-100 | 0.6-1.8 | 0.08 | 63 | 17 | 40-80 | 125 | $\mathbf{E}, \mathbf{H}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M/ ${ }_{\text {ds }}$ | Fast, Low Noise, Precision $\mathrm{A}_{\text {vcl }} \geqslant 5$ | 9-361 |
| OP07 | 25-150 | 0.6-2.5 | 0.35 | 0.6 | 0.3 | 2-12 | 98 | $\mathbf{E}, \mathbf{H}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | $\mathrm{C}, \mathrm{I}, \mathrm{M} / \mathrm{DJS}$ | Low Offset Voltage | 9-352 |
| AD846 | 25-200 | 0.8-5.0 | - | 75-450 | 450 | 250 | - | $\mathbf{N}, \mathbf{Q}$ | $\mathrm{I}, \mathrm{M} / \mathrm{DS}$ | High Precision, High Speed | 9-251 |
| AD708 | 30-100 | 0.3-1.0 | 0.23 | 0.9 | 0.3 | 1.0-2.5 | 100 | $\mathbf{H}, \mathbf{N}, \mathbf{Q}$ | C, I, M/ | Dual AD707 | 9-44 |
| AD797 | 40-100 | 0.8-1.5 | 0.05 | 100 | 18 | 50-1000 (typ) | 130 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | Ultralow Noise, Low Distortion Amp | 9-78 |
| AD706 | 50-100 | 0.5-1.0 | 0.5 | 0.8 | 0.15 | 0.11-0.20 | 110 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I | Dual AD705 | 9-40 |
| OP497 | 50-150 | 0.5-1.5 | 0.3 | 0.5 | 0.15 | 0.1-0.2 | 130 | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/ | Quad Precision, Low $\mathrm{I}_{\text {B }}$ | 9-568 |
| OP297 | 50-200 | 0.6-2 | 0.3 | 0.5 | 0.15 | 0.1-0.2 | 105 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/s | Dual Precision, Low Power, Low $\mathrm{I}_{\mathrm{B}}$ | 9-530 |
| OP113 | 75-150 | 0.8-1.5 | 0.12 | 3.4 | 1.2 | 50 | 116 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | 1 | Single Supply, Low Noise | 9-382 |
| AD704 | 75-150 | 1.0-1.5 | 0.5 | 0.8 | 0.1 | 0.15-0.27 | 110 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M | Quad AD705 | 9-40 |
| OP200 | 75-200 | 0.5-2 | 0.5 | 0.5 | 0.15 | 2-5 | 110 | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/ ${ }_{\text {DS }}$ | Dual Monolithic, Precision | 9-432 |
| OP270 | 75-250 | 1-3 | 0.08 | 5 | 2.4 | 20-60 | 115 | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/ ${ }_{\text {ds }}$ | Dual Monolithic, Low Power | 9-447 |
| OP227 | 80-180 | 1-1.8 | 0.08 | 8 | 2.8 | 40-80 | 125 | Q | I, $\mathrm{M} / \mathrm{DS}$ | Dual Matched, Low Noise | A 2-835 |
| OP207 | 100-200 | 1.3-1.8 | 0.35 | 0.6 | 0.2 | 3-7 | 98 | Q | C, $\mathrm{M} / \mathrm{DS}^{\text {d }}$ | Dual Matched, Precision | A 2-813 |
| OP213 | 100-250 | 0.8-1.5 | 0.12 | 3.4 | 1.2 | 50 | 116 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I | Dual Single Supply, Low Noise | 9-382 |
| OP413 | 125-275 | 0.8-1.5 | 0.12 | 3.4 | 1.2 | 50 | 116 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I | Quad Single Supply, Low Noise | 9-382 |
| AD844 | 150-300 | 5 | - | 900 | 2000 | 250 | - | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/s | Precision, High Speed | 9-245 |
| OP400 | 150-300 | 1.2-2.5 | 0.5 | 0.5 | 0.15 | 3-7 | 110 | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, $\mathrm{I}, \mathrm{M} /{ }_{\text {s }}$ | Quad, Monolithic, Precision | 9-534 |
| OP90 | 150-450 | 2-5 | 3 | - | - | 15-25 | 80 | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/s | Micropower, Low Voltage, Single Supply | 9-375 |
| OP221 | 150-500 | 1.5-3 | - | 0.6 | 0.3 | 80-120 | 60 | $\mathbf{H}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, $\mathrm{I}, \mathrm{M} / \mathrm{s}$ | Dual Low Power, Single Supply | 9-439 |
| OP220 | 150-750 | 1.5-3 | - | 0.2 | 0.05 | 20-30 | 30 | $\mathbf{H}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, $\mathrm{I}, \mathrm{M} / \mathrm{s}$ | Dual Micropower, Single Supply | 9-436 |
| OP05 | 150-1600 | 0.9-4.5 | 0.38 | 0.8 | 0.3 | 2.9 | - | H, N, Q | C, M/ | Instrumentation Amplifier | A 2-519 |
| OP271 | 200-400 | 2-5 | - | 5 | 8.5 | 20-60 | 125 | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | $\mathrm{I}, \mathrm{M} / \mathrm{DS}$ | Dual, Fast, Low Noise | 9-451 |


| Model | $\begin{aligned} & \mathbf{V}_{\mathrm{Os}} \\ & \boldsymbol{\mu \mathrm { V }} \\ & \max \end{aligned}$ | $V_{\text {os }}$ TC $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ max | Noise <br> $\mu \mathrm{V}$ p-p <br> $\mathbf{0 . 1 - 1 0 ~ H z}$ <br> typ | $\begin{aligned} & \text { GBW } \\ & \text { MHz } \\ & \text { typ } \end{aligned}$ | Slew <br> Rate <br> $\mathrm{V} / \mu \mathrm{s}$ <br> typ | $I_{B}$ nA max | CMRR <br> dB $\mathrm{f}=1 \mathrm{kHz}$ <br> typ | Package Options ${ }^{1}$ | Temp Ranges ${ }^{2}$ | Comments | Page ${ }^{3}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| OP290 | 200-500 | 3-5 | 3 | 0.02 | - | 15-25 | 100 | $\mathbf{N}, \mathbf{Q}, \mathbf{E}, \mathbf{R}$ | I, M/ ${ }_{\text {DS }}$ | Dual Micropower, Low Voltage Single Supply | 9-477 |
| OP467 | 200-1000 | 3.5 | 6 | 30 | 170 | - | 80 | $\mathbf{N}, \mathbf{Q}, \mathbf{P}, \mathbf{R}$ | C, I, M | Quad High Speed | 9-541 |
| AD795 | 250-500 | 1-10 | 1 | 2 | 1 | 0.001-0.004 | 110 | N, R, H | C, I, M | Low Power, Low Noise FET | 9-64 |
| OP20 | 250-1000 | 1.5-7 | - | 0.1 | 0.05 | 25-40 | 30 | N, Q, R, H | C, I, M/ | Micropower, Single Supply | A 2-585 |
| AD744 | 250-1000 | 3-20 | 2 | 13 | 75 | 0.05-0.1 | 100 | $\mathbf{H}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M | Fast Settling BiFET | 9-55 |
| AD820 | 250-1000 | 5-10 | 2 | 2 | 3.75 | 0.02-0.03 | 100 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M | Single Supply, Rail-to-Rail, FET Input | 9-170 |
| AD822 | 250-1000 | 5-10 | 2 | 2 | 3.75 | 0.02-0.03 | 100 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M | FET Dual AD820 | 9-170 |
| AD711 | 250-2000 | 3-20 | 2 | 4 | 20 | 0.025-0.050 | 94 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}, \mathbf{H}$ | C, I, M/ | Precision, High Speed | 9-47 |
| AD548 | 250-2000 | 2-20 | 2 | 1 | 1.8 | 0.01-0.02 | 83 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}, \mathbf{H}$ | C, I, M/ | Low Power BiFET | 9-25 |
| OP41 | 250-2000 | 5-10 | - | 0.5 | 1.3 | 0.005-0.02 | 100 | N, R, H | C, I, M/ | Low $\mathrm{I}_{\mathrm{B}}$ | A 2-645 |
| OP22 | 300-1000 | 1.5-3 | - | 0.25 | 0.08 | 5-10 | 60 | N, Q, R, H | C, I, M/ | Micropower, Programmable | A 2-597 |
| AD648 | 300-2000 | 3-20 | 2 | 1 | 1.8 | 0.01-0.02 | 83 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}, \mathbf{H}$ | C, I, M/ | Dual AD548 | 9-37 |
| AD712 | 300-3000 | 5-20 | 2 | 4 | 20 | 0.05-0.075 | 94 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}, \mathbf{H}$ | C, I, M/ | Dual AD711 | 9-47 |
| OP470 | 400-1000 | 2-4 | 0.08 | 6 | 2 | 25-60 | 110 | $\mathbf{N}, \mathbf{Q}, \mathbf{E}, \mathbf{R}$ | C, I, M/ Ds | Quad, Low Noise | 9-556 |
| AD713 | 500-1500 | 15-20 | 2 | 4 | 20 | 0.075-0.150 | 94 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M/D | Dual AD711 | 9-47 |
| AD741 | 500-6000 | 5-20 | - | 1 | 0.5 | 50-500 | 100 | N, H | C, M/ | General Purpose | A 2-213 |
| OP291/491 | 700 | 1.1 typ | 2 | 3 | 0.4 | 50 | 90 | N, R | I | Dual, Quad, Rail-to-Rail, 2.7 V | 9-481 |
| OP471 | 800-1800 | 4-7 | 0.25 | 6.5 | 8 | 25-60 | 108 | $\mathbf{N}, \mathbf{Q}, \mathbf{E}, \mathbf{R}$ | C, I, M/ ${ }_{\text {ds }}$ | Quad, Fast, Low Noise | 9-560 |

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## Selection Guides-Operational Amplifiers

## Low Power/Micropower Amplifiers

| Model | ISY <br> max <br> mA | $V_{\text {os }}$ max mV | $\mathrm{I}_{\mathrm{B}}$ <br> max <br> nA | $\begin{aligned} & \text { GBW } \\ & \text { typ } \\ & \text { MHz } \end{aligned}$ | SR <br> typ <br> V/ $\mu \mathrm{s}$ | Package Options ${ }^{1}$ | Temp Ranges ${ }^{2}$ | Comments | Page ${ }^{3}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| OP22 | 0.0002-0.4 | 0.3-1 | 5-10 | 0.25 | 0.08 | H, M, N, Q, R | I, M/ | Programmable, Single Supply | A 2-597 |
| OP90 | 0.02 | 0.15-0.45 | 15-25 | 0.02 | - | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{E}$ | I, M/s | Micropower, Low Voltage Single Supply | 9-375 |
| OP290 | 0.04 | 0.2-0.5 | 15-25 | 0.02 | - | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{E}$ | I, M/ ${ }_{\text {DS }}$ | Dual, Micropower, Low Voltage, Single Supply | 9-477 |
| OP20 | 0.08 | 0.25-1 | 25-40 | 0.1 | 0.05 | E, N, Q, R | I, M/ | Micropower, Single Supply, Low Cost | A 2-585 |
| OP490 | 0.08 | 0.5-1 | 15-25 | 0.02 | - | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/Ds | Quad, Micropower, Low Voltage, Single Supply | 9-564 |
| OP220 | 0.17 | 0.15-0.75 | 20-30 | 0.2 | 0.05 | $\mathbf{H}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/s | Dual, Low Cost, Micropower, Single Supply | 9-436 |
| AD548 | 0.2 | 0.25-0.2 | 0.01-0.02 | 1.0 | 1.8 | $\mathbf{H}, \mathbf{N}, \mathbf{Q}$ | C, I, M/ | Precision Low Power BifET Op Amp | 9-25 |
| OP295 | 0.3 | 0.2-0.5 | 15 | 0.085 | 0.04 | N, R | I, M | Dual Rail-to-Rail | 9-518 |
| OP80 | 0.325 | 1.5 | 0.00025-0.001 | 0.3 | 0.4 | H, N, R | I, M | Low $\mathrm{I}_{\mathrm{B}}$, CMOS | A 2-727 |
| OP420 | 0.36 | 2.5-6 | 20-40 | 0.15 | 0.05 | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/s | Quad, Low Cost, Micropower, Single Supply | 9-538 |
| OP21 | 0.3-0.4 | 0.1-0.5 | 100-150 | 0.6 | 0.25 | H, N, Q, R | I, M/ | Low Cost, Low Power, Single Supply | A 2-591 |
| OP291/491 | 0.35 | 0.7 | 50 | 3 | 0.4 | N, R | I | Rail-to-Rail, 2.7 V Supply | 9-481 |
| OP282 | 0.5 | 2.0 | 0.1 | 4 | 9 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I | Dual, High Speed, Low Power | 9-461 |
| AD648 | 0.4 | 0.4-2.0 | 0.005-. 01 | 1.0 | 1.8 | $\mathbf{H}, \mathbf{N}, \mathbf{Q}$ | C, I, M/ | Dual, Precision Low Power BiFET Op Amp | 9-37 |
| OP97 | 0.6 | 0.025-0.075 | 0.1-0.15 | 0.9 | 0.2 | $\mathbf{E}, \mathbf{H}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | $\mathrm{I}, \mathrm{M} / \mathrm{Ds}$ | Precision, Low $\mathrm{I}_{\mathrm{B}}$ | 9-379 |
| AD705 | 0.6 | 0.025-0.09 | 0.1-0.15 | 0.8 | 0.15 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M | Picoampere Input Current Bipolar Op Amp | 9-40 |
| AD820 | 0.66 | 0.25-1 | 0.02-0.03 | 2 | 3.75 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M | Fast, Single Supply, Rail-to-Rail FET Input | 9-170 |
| OP221 | 0.8 | 0.15-0.5 | 80-120 | 0.6 | 0.3 | $\mathbf{H}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/s | Dual, Low Cost, Low Power, Single Supply | 9-439 |
| OP41 | 1 | 0.25-2 | 0.005-0.02 | 0.5 | 1.3 | N, Q, R | I, M/ | Low Power, Low $\mathrm{I}_{\mathrm{B}}$ | A 2-645 |
| OP482 | 1.0 | 3.0 | 0.1 | 4 | 9 | $\mathbf{N}, \mathbf{P}, \mathbf{Q}, \mathbf{R}$ | I | Quad, High Speed, Low Power | 9-461 |
| AD706 | 1.2 | 0.05-0.1 | 0.11-0.2 | 0.8 | 0.15 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M | Dual, Picoampere Input Current Bipolar Op Amp | 9-40 |
| OP297 | 1,25 | 0.05-0.2 | 0.1-0.2 | 0.5 | 0.15 | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | $\mathrm{I}, \mathrm{M} / \mathrm{s}$ | Dual, Precision, Low $\mathrm{I}_{\mathrm{B}}$ | 9-530 |
| AD822 | 1.3 | 0.25-1 | 0.02-0.03 | 2 | 3.75 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M | Dual AD820 | 9-170 |
| OP200 | 1.45 | 0.075-0.2 | 2-5 | 0.5 | 0.15 | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/Ds | Dual, Precision | 9-432 |
| OP183/283 | 1.5 | 1.0 | 600 | 5 | 10 | N, R | 1 | 5 MHz , Low Noise, Single/Dual | 9-420 |
| OP421 | 1.8 | 2.5-6 | 50-150 | 1.9 | 0.5 | N, Q, R | I, $\mathrm{M}_{\mathrm{D}}$ | Quad, Low Cost, Low Power, Single Supply | A 2-993 |
| OP113/213/413 | 2.0 | 0.075-0.275 | 50 | 3.4 | 1.2 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | 1 | Low Noise, Low Drift, Single/Dual/Quad | 9-382 |
| AD704 | 2.4 | 0.075-0.150 | 0.15-0.17 | 1.0 | 0.15 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M | Quad, Picoampere Input Current Bipolar Op Amp | 9-40 |
| OP02. | 2.4 | 0.5-5 | 30-100 | 1.3 | 0.5 | H, N, Q | C, M/ | Improved 741 | A 2-503 |
| OP400 | 2.9 | 0.15-0.3 | 3-7 | 0.5 | 0.15 | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, $\mathbf{I}, \mathrm{M} / \mathrm{Ds}$ | Quad, Precision | 9-534 |




 temperature designator will be followed by: / to indicate 883B, , for JAN, ${ }_{\mathrm{D}}$ for SMD, and ${ }_{\mathrm{s}}$ for space level.
${ }^{3} \mathrm{~A}=$ Amplifier Reference Manual. All other entries refer to this volume.
Boldface Type: Data sheet information in this volume.

## Dual Operational Amplifiers

|  | Model | $\mathrm{V}_{\mathrm{os}}$ mV max | $\mathrm{V}_{\mathrm{os}} \mathrm{TC}$ $\mu \mathbf{V} /{ }^{\mathbf{T}} \mathbf{C}$ max | $\mathbf{I}_{\mathrm{B}}$ nA $\max ^{2}$ | BW <br> MHz <br> typ ${ }^{1}$ | Slew Rate <br> V/us <br> typ | Settling Time to $0.01 \% \mu \mathrm{~s}$ typ | Package Options ${ }^{2}$ | Temp Ranges ${ }^{3}$ | Comments | Page ${ }^{4}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | AD708 | 0.03-0.1 | 0.3-1.0 | 1-2.5 | 0.9 | 0.3 |  | H, N, Q | C, I, M/ | Highest DC Precision; Excellent Matching Between Amps, Dual AD707 | 9-44 |
|  | AD706 | 0.05-0.10 | 0.6-1.5 | 0.11-0.200 | 0.8 | 0.15 | - | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I | Dual AD705, Low $\mathrm{I}_{\mathrm{B}}$ Precision Bipolar | 9-40 |
|  | OP297 | 0.05-0.2 | 0.6-2 | 0.1-0.2 | 0.5 | 0.15 | - | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/s | Precision, Low Power, Low $\mathrm{I}_{\mathrm{B}}$ | 9-530 |
|  | OP200 | 0.075-0.2 | 0.5-2 | 2-5 | 0.5 | 0.15 | - | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | $\mathrm{I}, \mathrm{M} / \mathrm{DS}$ | Dual Monolithic, Precision | 9-432 |
|  | OP270 | 0.075-0.25 | 1-3 | 20-60 | 5 | 2.4 | - | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | $\mathrm{I}, \mathrm{M} / \mathrm{Ds}$ | Dual Monolithic, Low Noise | 9-447 |
|  | OP227 | 0.08-0.18 | 1-1.8 | 40-80 | 8 | 2.8 | - | Q | I, M/ ${ }_{\text {DS }}$ | Dual Matched, Low Noise | A 2-843 |
|  | OP207 | 0.1-0.2 | 1.3-1.8 | 3-7 | 0.6 | 0.2 | - | Q | C, M/DS | Dual Matched, Precision | A 2-813 |
|  | OP213 | 0.1-0.25 | 0.8-1.5 | 50 | 3.4 | 1.2 | 9 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | 1 | Low Noise, Low Drift, Single Supply | 9-382 |
|  | OP221 | 0.15-0.5 | 1.5-3 | 80-120 | 0.6 | 0.3 | - | $\mathbf{H}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M/s | Low Power, Single Supply | 9-439 |
|  | OP220 | 0.15-0.75 | 1.5-3 | 20-30 | 0.2 | 0.05 | - | $\mathbf{H}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M ${ }_{\text {s }}$ | Micropower, Single Supply | 9-436 |
|  | OP271 | 0.2-0.4 | 2-5 | 20-60 | 5 | 8.5 | - | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | $\mathrm{I}, \mathrm{M} / \mathrm{DS}^{\text {d }}$ | Dual Monolithic, Fast, Low Noise | 9-451 |
|  | OP290 | 0.2-0.5 | 3-5 | 15-25 | 0.02 | - | - | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | $\mathrm{I}, \mathrm{M} / \mathrm{DS}$ | Micropower, Low Voltage Single Supply | 9-477 |
|  | OP295 | 0.2-0.5 | $<10$ | 15 | 0.085 | 0.04 | - | N, R | $\mathbf{I}, \mathrm{M}$ | Rail-to-Rail | 9-518 |
|  | OP285 | 0.25 | - | 150 | 8 | 20 | - | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ |  | Dual High Performance, Low Power | 9-464 |
|  | AD822 | 0.25-1 | 5-10 | 0.02-0.03 | 2 | 3.75 | - | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M | Single Supply, Rail-to-Rail, Fast FET Input | 9-170 |
|  | AD746 | 0.5-1 | 10-20 | 0.15 | 13 | 75 | 0.5 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M/ | Precision, Fast Settling, Dual AD744 | 9-61 |
|  | AD648 | 0.3-2 | 3-20 | 0.01-0.02 | 1 | 1.8 | 8 | $\mathbf{H , N , Q}, \mathbf{R}$ | C, I, M/ | Low Power, BiFET, Dual AD548 | 9-37 |
|  | AD712 | 0.3-3 | 5-20 | 0.05-0.075 | 4 | 20 | 1 | $\mathbf{H}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M/ | Excellent AC and DC Performance, Dual AD711 | 9-47 |
|  | OP249 | 0.5-0.7 | 5-6 | 0.05-0.075 | 4.7 | 22 | 0.9 | $\mathbf{E , H}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/s | Fast, Low Distortion | 9-442 |
|  | AD642 | 0.5-2 | 1-3.5 | 0.035-0.075 | 1 | 3 | - | H | C, M/ | Dual AD542 | 9-31 |
|  | AD644 | 0.5-2 | - | 0.035-0.075 | 2 | 13 | - | H | C, M/ | Dual AD544 | 9-31 |
|  | OP291 | 0.7 | 1.1 typ | 50 | 3 | 0.4 | 22 | N, R | I | Rail-to-Rail, 2.7 V Supply, Low Power | 9-481 |
|  | OP15 | 0.75-5 | 8-20 | 50-100 | 1.3 | 0.5 | - | H, N, Q, R | $\mathrm{I}, \mathrm{M} / \mathrm{DS}$ | Improved "1458" Dual | A 2-571 |
|  | OP275 | 1 | - | 350 | 9 | 22 | - | N, R |  | Dual Audio Amp | 9-454 |
|  | OP283 | 1.0 | 4 typ | 600 | 5 | 10 | 1.5 | N, R | I | Low Power, Single Supply | 9-420 |
|  | AD828 | 2 | 10 typ | 6600 | 130 | 450 | 0.08 | N, R | I | Low Power Video Amp | 9-203 |
|  | OP215 | 1-4 | 10 | 0.1-0.3 | 5.7 | 18 | 0.9-0.1\% | E, H, N, Q, R | C, I, M/ ${ }_{\text {DS }}$ | High Speed, Precision | A 2-819 |
|  | OP282 | 2.0 | 10 | 0.1 | 4.0 | 9 | 1.5 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | 1 | Dual High Speed, Low Power | 9-461 |
| \% | AD827 | 4.0 | 15 | 7000 | 50 | 300 | 0.120-0.1\% | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, $\mathrm{I}, \mathrm{M} / \mathrm{D}$ | Dual AD847, High Speed, Low Power | 9-200 |
| P | OP279 | 4.0 | 4 typ | 600 | 2 | 5 | - | N, R | I | Rail-to-Rail, Single Supply, 50 mA Out | 9-459 |
| $\stackrel{1}{7}$ | OP260 | 3.5-7 | 10 | 1000-15000 | 90 | 1000 | 0.25-0.1\% | E, H, N, Q, R | I, $\mathrm{M}_{\text {dS }}$ | Dual High Speed, Current Feedback | A 2-873 |
| $\bigcirc$ | AD812 | 5 | 15 typ | 1000-20000 | 145 | 1600 | 0.05-0.1\% | $\mathbf{N}, \mathbf{R}$ | I | Dual Current Feedback, Low Power | 9-110 |
| $\Sigma$ | AD8002 | 5.5 | 10 typ | 6000-25000 | 880 | 1200 | 0.01-0.1\% | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I | 880 MHz, Low Power | 9-278 |

${ }^{1}$ Unity gain small signal bandwidth.
 Metal Can DIP; $N=$ Plastic or Epoxy Sealed DIP; $P=$ Plastic Leaded Chip Carrier; $Q=$ Cerdip; $R=$ Small Outline "SOIC" Package; RS = SSOP Quad Flatpack; $T=$ TO-92; $U=T$ Epoxy
 ignator will be followed by: / to indicate 883B, for JAN, ${ }_{\mathrm{D}}$ for SMD, and s for space level.
${ }^{4} \mathrm{~A}=$ Amplifier Reference Manual. All other entries refer to this volume.
Boldface Type: Data sheet information in this volume.

## Selection Guides—Operational Amplifiers

## Quad Operational Amplifiers

| Model | $V_{\text {os }}$ mV <br> max | $V_{\text {os }}$ TC $\mu \mathbf{V} /{ }^{\circ} \mathbf{C}$ $\max ^{1}$ | $\mathbf{I}_{B}$ nA max | BW <br> $\mathbf{M H z}$ <br> typ ${ }^{1}$ | Slew <br> Rate <br> $\mathrm{V} / \mu \mathrm{s}$ <br> typ | Settling Time to $0.01 \%$ $\mu \mathrm{s}$ typ | Package Options ${ }^{2}$ | Temp Ranges ${ }^{3}$ | Comments | Page ${ }^{4}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| AD704 | 0.075-0.10 | 1.0-1.5 | 150-270 | 0.8 | 0.10 | - | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M | Quad AD705, Low $\mathrm{I}_{\mathrm{B}}$ Precision Bipolar | 9-40 |
| OP497 | 0.05-0.15 | 0.5-1.5 | 150-200 | 0.5 | 0.15 | - | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/ | Low Power, Low $\mathrm{I}_{\mathrm{B}}$ Precision Bipolar | 9-568 |
| OP413 | 0.125-0.275 | 0.8-1.5 | 50 | 3.4 | 1.2 | 9 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I | Low Noise, Low Drift, Single Supply | 9-382 |
| OP400 | 0.15-0.3 | 1.2-2.5 | 3-7 | 0.5 | 0.15 | - | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M/w | Quad Monolithic, Precision | 9-534 |
| OP495 | 0.2-0.5 | <10 | 15 | 0.085 | 0.04 | - | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | Rail-to-Rail | 9-518 |
| OP470 | 0.4-1 | 2-4 | 25-60 | 6 | 2 | - | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | $\mathbf{C , I}, \mathrm{M} / \mathrm{Ds}$ | Quad Monolithic, Low Noise | 9-556 |
| OP467 | 0.5 | 3.5 | 100 | 30 | 170 | 170 | $\mathbf{N}, \mathbf{P}, \mathbf{Q}, \mathbf{R}$ |  | 30 MHz , Low Power | 9-541 |
| OP491 | 0.7 | 1.1 typ | 50 | 3 | 0.4 | 22 | N, $\mathbf{R}$ | I | Rail-to-Rail, 2.7 V Supply, Low Power | 9-481 |
| OP490 | 0.5-1 | 5 | 15-25 | 0.02 | 0.012 | - | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/bs | Micropower, Low Voltage, Single Supply | 9-564 |
| AD713 | 0.5-1.5 | 15 | 35-100 | 4 | 20 | 1 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M/w | Superior AC and DC Performance, Quad AD711 | 9-47 |
| OP11 | 0.5-5 | 10-15 | 300-500 | 3 | 1 | - | E, N, Q, R | C, I, M/ | Improved Quad "741" | A 2-547 |
| OP471 | 0.8-1.8 | 4-7 | 25-60 | 6.5 | 8 | - | $\mathbf{E , N}, \mathbf{Q}, \mathbf{R}$ | $\mathbf{C , I}, \mathrm{M} / \mathrm{Ds}$ | Monolithic, Fast, Low Noise | 9-560 |
| OP492 | 2.5 | 10 | 700 | 4 | 4 | - | N, R | I | Single Supply, Low Power, I/O to Ground | 9-500 |
| OP482 | 3.0 | 10 | 0.1 | 4.0 | 9 | 1.5 | $\mathbf{N}, \mathbf{Q}, \mathbf{P}, \mathbf{R}$ | I | High Speed, Low Power | 9-461 |
| OP421 | 2.5-6 | 10-15 | 50-150 | 1.9 | 0.5 | - | N, Q, R | I, M/ | Low Power, Low Cost, Single Supply | A 2-993 |
| OP420 | 2.5-6 | 10-25 | 20-40 | 0.15 | 0.05 | - | $\mathbf{E}, \mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/s | Micropower, Low Cost, Single Supply | 9-538 |
| AD8004 | 15 | 30 typ | 15000-25000 | 400 | 3000 | 0.01-0.1\% | N, R | 1 | 3000 V/ $/ \mathrm{s}$, Low Power | 9-291 |

Unity Gain Buffers

${ }^{1}$ Unity gain small signal bandwidth.
${ }^{2}$ Package Options: D = Hermetic DIP, Ceramic or Metal; E = Ceramic Leadless Chip Carrier; F = Ceramic Flatpack; G = Ceramic Pin Grid Array; H = Hermetic Metal Can; J = J-Leaded Ceramic Package;
$M=$ Hermetic Metal Can DIP; $\mathrm{N}=$ Plastic or Epoxy Sealed DIP; P = Plastic Leaded Chip Carrier; Q = Cerdip; R = Small Outline "SOIC" Package; RS = SSOP-Shrink Small Outline Package; S = Plastic Quad Flatpack; ST = Thin Quad Flatpack; $\mathrm{T}=\mathrm{TO}-92 ; \mathrm{U}=\mathrm{TSOP}-$ Thin Small Outline Package; $\mathrm{W}=$ Nonhermetic Ceramic/Glass DIP; $\mathrm{Y}=$ Single-In-Line "SIP" Package; $\mathrm{Z}=$ Ceramic Leaded Chip Carrier. ${ }^{3}$ Temperature Ranges: $\mathrm{C}=$ Commercial, $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C} ; \mathrm{I}=$ Industrial, $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ (Some older products $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ); M Military, $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. If a device has military grade offerings, the M temperature designator will be followed by: / to indicate 883B, , for JAN, ${ }_{D}$ for SMD, and ${ }_{s}$ for space level.
${ }^{4}$ A $=$ Amplifier Reference Manual. All other entries refer to this volume.
Boldface Type: Data sheet information in this volume.

ANALOG DEVICES

AD542/AD544/AD547

FEATURES
Ultralow Drift: $1 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ (AD547L)
Low Offset Voltage: 0.25 mV (AD547L)
Low Input Bias Currents: 25 pA max
Low Quiescent Current: 1.5 mA
Low Noise: $\mathbf{2 \mu V} \mathbf{p - p}$
High Open Loop Gain: 110 dB
High Slew Rate: $13 \mathrm{~V} / \mu \mathrm{s}$
Fast Settling to $\pm 0.01 \%$ : $3 \mu \mathrm{~s}$
Low Total Harmonic Distortion: 0.0025\%
Available in Hermetic Metal Can and Die Form
MIL-STD-883B Versions Available
Dual Versions Available: AD642, AD644, AD647

## PRODUCT DESCRIPTION

The BiFET series of precision, monolithic FET-input op amps are fabricated with the most advanced BiFET and laser trimming technologies. The AD542, AD544, AD547 series offers bias currents significantly lower than currently available BiFET devices, 25 pA max, warmed up.
In addition, the offset voltage is laser trimmed to less than 0.25 mV on the AD547L, which is achieved by utilizing Analog Devices' exclusive laser wafer trimming (LWT) process. When combined with the AD547's low offset drift $\left(1 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}\right)$, these features offer the user performance superior to existing BiFET op amps at low BiFET pricing.
The AD542 or AD547 is recommended for any operational amplifier application requiring excellent dc performance at low to moderate cost. Precision instrument front ends requiring accurate amplification of millivolt level signals from megohm source impedances will benefit from the device's excellent combination of low offset voltage and drift, low bias current and low $1 / \mathrm{f}$ noise. High common-mode rejection ( $80 \mathrm{~dB}, \mathrm{~min}$ on the " K " and "L" grades) and high open-loop gain, even under heavy loading, ensures better than "12-bit" linearity in high impedance buffer applications.

The AD544 is recommended for any op amp applications requiring excellent ac and dc performance at low cost. The 2 MHz bandwidth and low offset of the AD544 make it the first choice as an output amplifier for current output D/A converters, such as the AD7541, 12-bit CMOS DAC.
Devices in this series are available in four grades: the "J," "K," and " $L$ " grades are specified over the $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ temperature range and the " S " grade over the $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ operating temperature range. All devices are offered in the hermetically sealed, TO-99 metal can package.

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## PRODUCT HIGHLIGHTS

1. Improved bipolar and JFET processing results in the lowest bias current available in a monolithic FET op amp.
2. Analog Devices, unlike some manufacturers, specifies each device for the maximum bias current at either input in the warmed-up condition, thus assuring the user that the device will meet its published specifications in actual use.
3. Advanced laser wafer trimming techniques reduce offset voltage drift to $1 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ max and offset voltage to only 0.25 mV max on the AD547L.
4. Low voltage noise ( $2 \mu \mathrm{~V}$ p-p) and low offset voltage drift enhance performance as a precision op amp.
5. High slew rate ( $13 \mathrm{~V} / \mu \mathrm{s}$ ) and fast settling time to $0.01 \% ~(3 \mu \mathrm{~s})$ make the AD544 ideal for D/A, A/D, sample-hold circuits and high speed integrators.
6. Low harmonic distortion ( $0.0025 \%$ ) make the AD544 an ideal choice in audio applications.
7. Bare die are available for use in hybrid circuit applications.

## 

| Parameter | Min | $\begin{aligned} & \text { AD5 } \\ & \text { Typ } \\ & \hline \end{aligned}$ | Max | Min | $\begin{aligned} & \text { AD544 } \\ & \text { Typ } \\ & \hline \end{aligned}$ | Max | Min | $\begin{aligned} & \text { ADs } \\ & \text { Typ } \\ & \hline \end{aligned}$ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { OPEN-LOOP GAIN }{ }^{1} \\ & \mathrm{~V}_{\text {OUT }}= \pm 10 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & \mathrm{~J} \text { Grade } \\ & \mathrm{K}, \mathrm{~L}, \mathrm{~S} \text { Grades } \\ & \mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }} \text { to } \mathrm{T}_{\mathrm{MAX}} \\ & \mathrm{~J} \text { Grade } \\ & \mathrm{S} \text { Grade } \\ & \mathrm{K}, \mathrm{~L} \text { Grades } \end{aligned}$ | $\begin{aligned} & 100 \\ & \mathbf{2 5 0} \\ & \\ & 100 \\ & 100 \\ & 250 \end{aligned}$ |  |  | $\begin{aligned} & 30 \\ & 50 \\ & 20 \\ & 20 \\ & 40 \end{aligned}$ |  |  | $\begin{aligned} & 100 \\ & 250 \\ & \\ & 100 \\ & 100 \\ & 250 \end{aligned}$ |  |  | $\begin{aligned} & \mathrm{V} / \mathrm{mV} \\ & \mathrm{~V} / \mathrm{mV} \\ & \mathrm{~V} / \mathrm{mV} \\ & \mathrm{~V} / \mathrm{mV} \\ & \mathrm{~V} / \mathrm{mV} \end{aligned}$ |
| OUTPUT CHARACTERISTICS $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }} \text { to } \mathrm{T}_{\mathrm{MAX}} \\ & \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \\ & \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }} \text { to } \mathrm{T}_{\mathrm{MAX}} \\ & \text { Short Circuit Current } \end{aligned}$ | $\begin{aligned} & \pm 10 \\ & \pm 12 \end{aligned}$ | $\begin{aligned} & \pm 12 \\ & \pm 13 \\ & 25 \end{aligned}$ |  | $\begin{aligned} & \pm 10 \\ & \pm 12 \end{aligned}$ | $\begin{aligned} & \pm 12 \\ & \pm 13 \\ & 25 \end{aligned}$ |  | $\begin{aligned} & \pm 10 \\ & \pm 12 \end{aligned}$ | $\begin{aligned} & \pm 12 \\ & \pm 13 \\ & 25 \end{aligned}$ |  | V <br> V <br> mA |
| FREQUENCY RESPONSE <br> Unity Gain, Small Signal <br> Full Power Response Slew Rate, Unity Gain Total Harmonic Distortion | 2.0 | $\begin{aligned} & 1.0 \\ & 50 \\ & 3.0 \end{aligned}$ |  | 8.0 | $\begin{aligned} & 2.0 \\ & 200 \\ & 13.0 \\ & 0.0025 \end{aligned}$ |  | 2.0 | $\begin{aligned} & 1.0 \\ & 50 \\ & 3.0 \end{aligned}$ |  | MHz <br> kHz <br> $\mathrm{V} / \mathrm{\mu}$ <br> \% |
| INPUT OFFSET VOLTAGE ${ }^{2}$ <br> J Grade <br> K Grade <br> L Grade <br> S Grade <br> vs. Temperature ${ }^{3}$ <br> J Grade <br> K Grade <br> L Grade <br> S Grade <br> vs. Supply, $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\mathrm{MAX}}$ J Grade <br> K, L, S Grades |  |  | $\begin{aligned} & 2.0 \\ & 1.0 \\ & 0.5 \\ & 1.0 \\ & 20 \\ & 10 \\ & 5 \\ & 15 \\ & \\ & 200 \\ & 100 \end{aligned}$ |  |  | $\begin{aligned} & 2.0 \\ & 1.0 \\ & 0.5 \\ & 1.0 \\ & 20 \\ & 10 \\ & 5 \\ & 15 \\ & \\ & 200 \\ & 100 \end{aligned}$ |  |  | 1.0 <br> 0.5 <br> 0.25 <br> 0.5 <br> 5 <br> 2 <br> 1 <br> 5 <br> 200 <br> 100 | mV <br> mV <br> mV <br> mV <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ <br> $\mu \mathrm{V} / \mathrm{V}$ <br> $\mu \mathrm{V} / \mathrm{V}$ |
| INPUT BIAS CURRENT ${ }^{4}$ <br> Either Input J Grade K, L, S Grades Input Offset Current J Grade K, L, S Grades |  | $\begin{aligned} & 10 \\ & 5 \\ & 2 \end{aligned}$ | $\begin{aligned} & 50 \\ & 25 \\ & \\ & 15 \\ & 15 \end{aligned}$ |  | 10 <br> 5 <br> 2 | $\begin{aligned} & 50 \\ & 25 \\ & \\ & 15 \\ & 15 \end{aligned}$ |  | $\begin{aligned} & 10 \\ & 5 \\ & 2 \end{aligned}$ | $\begin{aligned} & 50 \\ & 25 \\ & \\ & 15 \\ & 15 \end{aligned}$ | pA <br> pA <br> pA <br> pA |
| INPUT IMPEDANCE Differential Common Mode |  | $\begin{aligned} & 10^{12} \\| 6 \\ & 10^{12} \\| 3 \end{aligned}$ |  |  | $\begin{aligned} & 10^{12} \\| 6 \\ & 10^{12} \mid{ }^{1} \end{aligned}$ |  |  | $\begin{aligned} & 10^{12} \\| 6 \\ & 10^{12} \mid{ }^{1} \\ & \hline \end{aligned}$ |  | $\begin{aligned} & \Omega \\| \mathrm{pF} \\ & \Omega \\| \mathrm{pF} \end{aligned}$ |
| INPUT VOLTAGE ${ }^{5}$ <br> Differential Common Mode Common-Mode Rejection $\mathrm{V}_{\text {IN }}= \pm 10 \mathrm{~V}$ J Grade K, L, S Grades | $\begin{aligned} & \pm 10 \\ & \\ & 76 \\ & 80 \end{aligned}$ | $\begin{aligned} & \pm 20 \\ & \pm 12 \end{aligned}$ |  | $\begin{aligned} & \pm 10 \\ & \\ & 76 \\ & 80 \end{aligned}$ | $\begin{aligned} & \pm 20 \\ & \pm 12 \end{aligned}$ |  | $\begin{aligned} & \pm 10 \\ & \\ & \mathbf{7 6} \\ & \mathbf{8 0} \end{aligned}$ | $\begin{aligned} & \pm 20 \\ & \pm 12 \end{aligned}$ |  | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \end{aligned}$ |



## NOTES

${ }^{1}$ Open-Loop Gain is specified with $\mathrm{V}_{\mathrm{Os}}$ both nulled and unnulled.
${ }^{2}$ Input Offset Voltage specifications are guaranteed after 5 minutes of operation at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.
${ }^{3}$ Input Offset Voltage Drift is specified with the offset voltage unnulled. Nulling will induce an additional $3 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C} / \mathrm{mV}$ of nulled offset.
${ }^{4}$ Bias Current specifications are guaranteed at either input after 5 minutes of operation at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. For higher temperatures, the current doubles every $10^{\circ} \mathrm{C}$.
${ }^{5}$ Defined as the maximum safe voltage between inputs, such that neither exceeds $\pm 10 \mathrm{~V}$ from ground.
Specifications subject to change without notice.
Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.

## ORDERING GUIDE

| Model | Initial <br> Offset <br> Voltage | Offset Voltage Drift | Settling Time to $\pm 0.012 \%$ for a 10 V Step | Package Description | Package Option ${ }^{\star}$ |
| :---: | :---: | :---: | :---: | :---: | :---: |
| AD542JCHIPS | 2.0 mV | $20 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ | $5 \mu \mathrm{~s}$ | Bare Die |  |
| AD542JH | 2.0 mV | $20 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ | $5 \mu \mathrm{~s}$ | 8-Pin Hermetic Metal Can | H-08A |
| AD542KH | 1.0 mV | $10 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ | $5 \mu \mathrm{~s}$ | 8-Pin Hermetic Metal Can | H-08A |
| AD542LH | 0.5 mV | $5 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ | $5 \mu \mathrm{~s}$ | 8-Pin Hermetic Metal Can | H-08A |
| AD542SH | 1.0 mV | $15 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ | $5 \mu \mathrm{~s}$ | 8-Pin Hermetic Metal Can | H-08A |
| AD542SH/883B | 1.0 mV | $15 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ | $5 \mu \mathrm{~s}$ | 8-Pin Hermetic Metal Can | H-08A |
| AD544JH | 2.0 mV | $20 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ | $3 \mu \mathrm{~s}$ | 8-Pin Hermetic Metal Can | H-08A |
| AD544KH | 1.0 mV | $10 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ | $3 \mu \mathrm{~s}$ | 8-Pin Hermetic Metal Can | H-08A |
| AD544LH | 0.5 mV | $5 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ | $3 \mu \mathrm{~s}$ | 8-Pin Hermetic Metal Can | H-08A |
| AD544SH | 1.0 mV | $15 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ | $3 \mu \mathrm{~s}$ | 8-Pin Hermetic Metal Can | H-08A |
| AD544SH/883B | 1.0 mV | $15 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ | $3 \mu \mathrm{~s}$ | 8-Pin Hermetic Metal Can | H-08A |
| AD547JH | 1.0 mV | $5 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ | $5 \mu \mathrm{~s}$ | 8-Pin Hermetic Metal Can | H-08A |
| AD547KH | 0.5 mV | $2 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ | $5 \mu \mathrm{~s}$ | 8-Pin Hermetic Metal Can | H-08A |
| AD547LH | 0.25 mV | $1 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ | $5 \mu \mathrm{~s}$ | 8 -Pin Hermetic Metal Can | H-08A |
| AD547SCHIPS | 0.5 mV | $5 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ | $5 \mu \mathrm{~s}$ | Bare Die |  |
| AD547SH/883B | 0.5 mV | $5 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ | $5 \mu \mathrm{~s}$ | 8-Pin Hermetic Metal Can | H-08A |

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## FEATURES

DC PERFORMANCE
1 mV max Input Offset Voltage
Low Offset Drift: $20 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$
1 pA max Input Bias Current
Input Bias Current Guaranteed Over Full
Common-Mode Voltage Range
AC PERFORMANCE
3 V/ $\mu \mathrm{s}$ Slew Rate
1 MHz Unity Gain Bandwidth
Low Input Voltage Noise: $\mathbf{4 \mu V} \mathbf{p - p , 0 . 1 ~ H z ~ t o ~} 10 \mathrm{~Hz}$
Available in a Low Cost, 8-Pin Plastic Mini-DIP
Standard Op Amp Pinout

## APPLICATIONS

## Electrometer Amplifiers

Photodiode Preamps
pH Electrode Buffers
Log Ratio Amplifiers

## PRODUCT DESCRIPTION

The AD546 is a monolithic electrometer combining the virtues of low ( 1 pA ) input bias current with the cost effectiveness of a plastic mini-DIP package. Both input offset voltage and input offset voltage drift are laser trimmed, providing very high performance for such a low cost amplifier.
Input bias currents are reduced significantly by using "topgate" JFET technology. The $10^{15} \Omega$ common-mode impedance, resulting from a bootstrapped input stage, insures that input bias current is essentially independent of common-mode voltage variations.

The AD546 is suitable for applications requiring both minimal levels of input bias current and low input offset voltage. Applications for the AD546 include use as a buffer amplifier for current output transducers such as photodiodes and pH probes. It may also be used as a precision integrator or as a low droop rate sample and hold amplifier. The AD546 is pin compatible with standard op amps; its plastic mini-DIP package is ideal for use with automatic insertion equipment.
The AD546 is available in two performance grades, all rated over the 0 to $+70^{\circ} \mathrm{C}$ commercial temperature range, and packaged in an 8 -pin plastic mini-DIP.

## CONNECTION DIAGRAM



## PRODUCT HIGHLIGHTS

1. The input bias current of the AD546 is specified, $100 \%$ tested and guaranteed with the device in the fully warmed-up condition.
2. The input offset voltage of the AD546 is laser trimmed to less than 1 mV (AD546K).
3. The AD546 is packaged in a standard, low cost, 8 -pin mini-DIP.
4. A low quiescent supply current of $700 \mu \mathrm{~A}$ minimizes any thermal effects which might degrade input bias current and input offset voltage specifications.
[^126]This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

|  |  |  | AD546J |  |  | AD546K |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Model | Conditions | Min | Typ | Max | Min | Typ | Max | Units |
| INPUT BIAS CURRENT ${ }^{1}$ |  |  |  |  |  |  |  |  |
| Either Input | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ |  | 0.2 | 1 |  | 0.2 | 0.5 | pA |
| Either Input | $\mathrm{V}_{\mathrm{CM}}= \pm 10 \mathrm{~V}$ |  | 0.2 | 1 |  | 0.2 | 0.5 | pA |
| Either Input |  |  |  |  |  |  |  |  |
| Either Input | $\mathrm{V}_{\mathrm{CM}}= \pm 10 \mathrm{~V}$ |  | 40 |  |  | 20 |  | pA |
| Offset Current | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ |  | 0.17 |  |  | 0.09 |  | pA |
| Offset Current <br> @ $\mathrm{T}_{\text {max }}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ |  |  |  |  |  |  | pA |
| INPUT OFFSET VOLTAGE ${ }^{2}$ |  |  |  |  |  |  |  |  |
|  |  |  |  |  |  |  |  |  |
|  |  |  |  |  |  |  |  |  |
|  |  |  |  |  |  |  |  |  |
|  |  |  |  |  |  |  |  |  |
|  |  |  |  |  |  |  |  |  |
| INPUT VOLTAGE NOISE |  |  |  |  |  |  |  |  |
|  | $\mathrm{f}=0.1 \mathrm{~Hz}$ to 10 Hz |  | 4 |  |  | 4 |  | $\mu \mathrm{V}$ p-p |
|  | $\mathrm{f}=10 \mathrm{~Hz}$ |  | 90 |  |  | 90 |  | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
|  | $\mathrm{f}=100 \mathrm{~Hz}$ |  | 60 |  |  | 60 |  | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
|  | $\mathrm{f}=1 \mathrm{kHz}$ |  | 35 |  |  | 35 |  | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
|  | $\mathrm{f}=10 \mathrm{kHz}$ |  | 35 |  |  | 35 |  | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| INPUT CURRENT NOISE |  |  |  |  |  |  |  |  |
|  | $\mathrm{f}=0.1 \mathrm{~Hz}$ to 10 Hz |  | 1.3 |  |  | 1.3 |  | fA rms |
|  | $\mathrm{f}=1 \mathrm{kHz}$ |  | 0.4 |  |  | 0.4 |  | $\mathrm{fA} / \sqrt{\mathrm{Hz}}$ |
| INPUT IMPEDANCE |  |  |  |  |  |  |  |  |
| Differential | $\mathrm{V}_{\text {DIFF }}= \pm 1 \mathrm{~V}$ |  | $10^{13} \mid 1$ |  |  | $10^{13} \mid 1$ |  | $\Omega \\| \mathrm{pF}$ |
| Common Mode | $\mathrm{V}_{\mathrm{CM}}= \pm 10 \mathrm{~V}$ |  | $10^{15}\| \| 0.8$ |  |  | $10^{15} \mid 0.8$ |  | $\Omega \\| \mathrm{pF}$ |
| OPEN LOOP GAIN | $\mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V}$ |  |  |  |  |  |  |  |
|  | $\mathrm{R}_{\text {LOAD }}=10 \mathrm{k} \Omega$ | 300 | 1000 |  | 300 | 1000 |  | $\mathrm{V} / \mathrm{mV}$ |
| $\mathrm{T}_{\text {min }}-\mathrm{T}_{\text {max }}$ | $\mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V}$ |  |  |  |  |  |  |  |
|  | $\mathrm{R}_{\text {LOAD }}=10 \mathrm{k} \Omega$ | 300 | 800 |  | 300 | 800 |  | $\mathrm{V} / \mathrm{mV}$ |
|  | $\mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V}$ |  |  |  |  |  |  |  |
|  | $\mathrm{R}_{\text {LOAD }}=2 \mathrm{k} \Omega$ | 100 | 250 |  | 100 | 250 |  | V/mV |
| $\mathrm{T}_{\text {min }}-\mathrm{T}_{\text {max }}$ | $\mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V}$ |  |  |  |  |  |  |  |
|  | $\mathrm{R}_{\text {LOAD }}=2 \mathrm{k} \Omega$ | 80 | 200 |  | 80 | 200 |  | V/mV |
| INPUT VOLTAGE RANGE |  |  |  |  |  |  |  |  |
| Differential ${ }^{3}$ |  |  | $\pm 20$ |  |  | $\pm 20$ |  | V |
| Common-Mode Voltage |  | -10 |  | +10 | -10 |  | +10 | V |
| Common-Mode |  |  |  |  |  |  |  |  |
| Rejection Ratio | $\mathrm{V}_{\mathrm{CM}}= \pm 10 \mathrm{~V}$ | 80 | 90 |  | 84 | 100 |  | dB |
|  | $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ | 76 | 80 |  | 76 | 80 |  | dB |
| OUTPUT CHARACTERISTICS |  |  |  |  |  |  |  |  |
| Voltage | $\mathrm{R}_{\text {LOAD }}=10 \mathrm{k} \Omega$ | -12 |  | +12 | -12 |  | +12 | V |
|  | $\mathrm{R}_{\text {LOAD }}=2 \mathrm{k} \Omega$ | -10 |  | +10 | -10 |  | +10 | V |
| Current | Short Circuit | 15 | 20 | 35 | 15 | 20 | 35 | mA |
| Load Capacitance |  |  |  |  |  |  |  |  |


|  |  |  | AD5 |  |  | AD54 |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Model | Conditions | Min | Typ | Max | Min | Typ | Max | Units |
| FREQUENCY RESPONSE |  |  |  |  |  |  |  |  |
| Gain BW, Small Signal | $\mathrm{G}=-1$ | 0.7 | 1.0 |  | 0.7 | 1.0 |  | MHz |
| Full Power Response | $\mathrm{V}_{\mathrm{O}}=20 \mathrm{~V}-\mathrm{p}$ |  | 50 |  |  | 50 |  | kHz |
| Slew Rate, Unity Gain | $\mathrm{G}=-1$ | 2 | 3 |  | 2 | 3 |  | V/us |
| Settling Time | to 0.1\% |  | 4.5 |  |  | 4.5 |  | $\mu \mathrm{s}$ |
|  | to 0.01\% |  | 5 |  |  | 5 |  | $\mu \mathrm{s}$ |
| Overload Recovery | 50\% Overdrive |  |  | ; |  |  |  |  |
|  | Gain $=-1$ |  | 2 |  |  | 2 |  | $\mu \mathrm{s}$ |
| POWER SUPPLY |  |  |  |  |  |  |  |  |
| Rated Performance |  |  | $\pm 15$ |  |  | $\pm 15$ |  | V |
| Operating Range |  | $\pm 5$ |  | $\pm 18$ | $\pm 5$ |  | $\pm 18$ | V |
| Quiescent Current |  |  | 0.60 | 0.7 |  | 0.60 | 0.7 | mA |
| Transistor Count | \# of Transistors |  | 50 |  |  | 50 |  |  |
| PACKAGE OPTIONS ${ }^{4}$ Plastic Mini-DIP (N-8) |  |  |  |  |  |  |  |  |
|  |  | AD546JN |  |  | AD546KN |  |  |  |

## NOTES

${ }^{1}$ Bias current specifications are guaranteed maximum, at either input, after 5 minutes of operation at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. Bias current increases by a factor of 2.3 for every $10^{\circ} \mathrm{C}$ rise in temperature.
${ }^{2}$ Input offset voltage specifications are guaranteed after 5 minutes of operation at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.
${ }^{3}$ Defined as max continuous voltage between inputs, such that neither exceeds $\pm 10 \mathrm{~V}$ from ground.
${ }^{4}$ For outline information see Package Information section.
Specifications subject to change without notice.
Specifications in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 18$ V
Internal Power Dissipation . . . . . . . . . . . . . . . . . . 500 mW
Input Voltage ${ }^{2}$. . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 18$ V
Output Short Circuit Duration . . . . . . . . . . . . . . . Indefinite
Differential Input Voltage . . . . . . . . . . . . . . $+V_{\text {S }}$ and $-V_{S}$
Storage Temperature Range . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Operating Temperature Range . . . . . . . . . . . . . . 0 to $+70^{\circ} \mathrm{C}$
Lead Temperature Range
(Soldering 60 seconds) . . . . . . . . . . . . . . . . . . . . . 300 C

## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ For supply voltages less than $\pm 18 \mathrm{~V}$, the absolute maximum input voltage is equal to the supply voltage.

## ESD PRECAUTIONS

Charges as high as 4000 V readily accumulate on the human body and test equipment and discharge without detection. Therefore, reasonable ESD precautions are recommended to avoid functional damage or performance degradation. Unused devices should be stored in conductive foam or shunts, and the foam should be discharged to the destination socket before devices are removed. For further information on ESD precautions, refer to Analog Devices' ESD Prevention Manual.

## FEATURES

Enhanced Replacement for LF441 and TL061 DC Performance:<br>$200 \mu \mathrm{~A}$ max Quiescent Current 10pA max Bias Current, Warmed Up (AD548C)<br>$250 \mu \mathrm{~V}$ max Offset Voltage (AD548C)<br>$2 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ max Drift (AD548C)<br>$\mathbf{2 \mu V}$ p-p Noise, 0.1 to 10 Hz<br>AC Performance:<br>$1.8 \mathrm{~V} / \mu \mathrm{s}$ Slew Rate<br>1MHz Unity Gain Bandwidth<br>Available in Plastic, Hermetic Cerdip and Hermetic Metal Can Packages and in Chip Form<br>Available in Tape and Reel in Accordance with<br>EIA-481A Standard<br>MIL-STD-883B Parts Available<br>Dual Version Available: AD648<br>Surface Mount (SOIC) Package Available

## PRODUCT DESCRIPTION

The AD548 is a low power, precision monolithic operational amplifier. It offers both low bias current ( 10 pA max, warmed up) and low quiescent current ( $200 \mu \mathrm{~A} \max$ ) and is fabricated with ion-implanted FET and laser wafer trimming technologies. Input bias current is guaranteed over the AD548's entire commonmode voltage range.
The economical J grade has a maximum guaranteed input offset voltage of less than 2 mV and an input offset voltage drift of less than $20 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$. The C grade reduces input offset voltage to less than 0.25 mV and offset voltage drift to less than $2 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$. This level of dc precision is achieved utilizing Analog's laser wafer drift trimming process. The combination of low quiescent current and low offset voltage drift minimizes changes in input offset voltage due to self-heating effects. Four additional grades are offered over the commercial, industrial and military temperature ranges.
The AD548 is recommended for any dual supply op amp application requiring low power and excellent dc and ac performance. In applications such as battery-powered, precision instrument front ends and CMOS DAC buffers, the AD548's excellent combination of low input offset voltage and drift, low bias current and low 1/f noise reduces output errors. High common-mode rejection ( 86 dB , min on the " C " grade) and high open-loop gain ensures better than 12-bit linearity in high impedance, buffer applications.
The AD548 is pinned out in a standard op amp configuration and is available in six performance grades. The AD548J and

## CONNECTION DIAGRAMS



AD548K are rated over the commercial temperature range of 0 to $+70^{\circ} \mathrm{C}$. The AD548A, AD548B and AD548C are rated over the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. The AD548S is rated over the military temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ and is available processed to MIL-STD-883B, Rev. C.
The AD548 is available in an 8-pin plastic mini-DIP, cerdip, TO-99 metal can, surface mount (SOIC), or in chip form.

## PRODUCT HIGHLIGHTS

1. A combination of low supply current, excellent dc and ac performance and low drift makes the AD548 the ideal op amp for high-performance, low-power applications.
2. The AD548 is pin compatible with industry standard op amps such as the LF441, TL061, and AD542, enabling designers to improve performance while achieving a reduction in power dissipation of up to $85 \%$.
3. Guaranteed low input offset voltage ( 2 mV max) and drift ( $20 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ max) for the AD548J are achieved utilizing Analog Devices' laser drift trimming technology, eliminating the need for external trimming.
4. Analog Devices specifies each device in the warmed-up condition, insuring that the device will meet its published specifications in actual use.
5. A dual version, the AD648 is also available.
6. Enhanced replacement for LF441 and TL061.

[^127](@ $+25^{\circ} \mathrm{C}$ and $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}$ dc, unless otherwise noted)


## NOTES

${ }^{1}$ Input Offset Voltage specifications are guaranteed after 5 minutes of
operation at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.
${ }^{2}$ Bias Current specifications are guaranteed maximum at either input after
5 minutes of operation at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. For higher temperature, the current doubles every $10^{\circ} \mathrm{C}$.
${ }^{3}$ Defined as voltages between inputs, such that neither exceeds $\pm 10 \mathrm{~V}$ from ground.
${ }^{4}$ For outline information see Package Information section.
Specifications subject to change without notice.


## METALIZATION PHOTOGRAPH

Contact factory for latest dimensions.
Dimensions shown in inches and (mm).


## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 volts, which readily accumulate on the human body and on test equipment, can discharge without detection. Although devices feature proprietary ESD protection circuitry, permanent damage may still occur on these devices if they are subjected to high energy electrostatic discharges. Therefore, proper precautions are recommended to avoid any performance degradation or loss of functionality.

ANALOG

## FEATURES

Ultralow Bias Current: 60 fA max (AD549L)
250 fA max
(AD549J)
Input Bias Current Guaranteed Over Common-Mode Voltage Range
Low Offset Voltage: 0.25 mV max (AD549K)
1.00 mV max (AD549J)

Low Offset Drift: $5 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C} \max (A D 549 K)$
$20 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C} \max$ (AD549J)
Low Power: $700 \mu \mathrm{~A}$ max Supply Current
Low Input Voltage Noise: $4 \boldsymbol{\mu} \mathrm{~V}$ p-p 0.1 to 10 Hz
MIL-STD-883B Parts Available

## APPLICATIONS

Electrometer Amplifiers<br>Photodiode Preamp<br>pH Electrode Buffer<br>Vacuum Ion Gage Measurement

## PRODUCT DESCRIPTION

The AD549 is a monolithic electrometer operational amplifier with very low input bias current. Input offset voltage and input offset voltage drift are laser trimmed for precision performance. The AD549's ultralow input current is achieved with "Topgate" JFET technology, a process development exclusive to Analog Devices. This technology allows the fabrication of extremely low input current JFETs compatible with a standard junctionisolated bipolar process. The $10^{15} \Omega$ common-mode impedance, a result of the bootstrapped input stage, insures that the input current is essentially independent of common-mode voltage.
The AD549 is suited for applications requiring very low input current and low input offset voltage. It excels as a preamp for a wide variety of current output transducers such as photodiodes, photomultiplier tubes, or oxygen sensors. The AD549 can also be used as a precision integrator or low droop sample and hold. The AD549 is pin compatible with standard FET and electrometer op amps, allowing designers to upgrade the performance of present systems at little additional cost.
The AD549 is available in a TO-99 hermetic package. The case is connected to Pin 8 so that the metal case can be independently connected to a point at the same potential as the input terminals, minimizing stray leakage to the case.
The AD549 is available in four performance grades. The J, K, and L versions are rated over the commercial temperature range

## CONNECTION DIAGRAM



0 to $+70^{\circ} \mathrm{C}$. The S grade is specified over the military temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ and is available processed to MIL-STD-883B, Rev C. Extended reliability PLUS screening is also available. PLUS screening includes 168 -hour burn-in, as well as other environmental and physical tests derived from MIL-STD-883B, Rev C.

## PRODUCT HIGHLIGHTS

1. The AD549's input currents are specified, $100 \%$ tested and guaranteed after the device is warmed up. Input current is guaranteed over the entire common-mode input voltage range.
2. The AD549's input offset voltage and drift are laser trimmed to 0.25 mV and $5 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}(\mathrm{AD} 549 \mathrm{~K}), 1 \mathrm{mV}$ and $20 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ (AD549J).
3. A maximum quiescent supply current of $700 \mu \mathrm{~A}$ minimizes heating effects on input current and offset voltage.
4. AC specifications include 1 MHz unity gain bandwidth and $3 \mathrm{~V} / \mu \mathrm{s}$ slew rate. Settling time for a 10 V input step is $5 \mu \mathrm{~s}$ to $0.01 \%$.
5. The AD549 is an improved replacement for the AD515, OPA104, and 3528.
[^128][^129]


## NOTES

${ }^{1}$ Bias current specifications are guaranteed after 5 minutes of operation at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. Bias current increases by a factor of 2.3 for every $10^{\circ} \mathrm{C}$ rise in temperature.
${ }^{2}$ Input offset voltage specifications are guaranteed after 5 minutes of operation at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$
${ }^{3}$ Defined as max continuous voltage between the inputs such that neither input exceeds $\pm 10 \mathrm{~V}$ from ground.
${ }^{4}$ For outline information see Package Information section.
Specifications subject to change without notice.
All min and max specifications are guaranteed. Specifications in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels.

ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

| Supply Voltage |  |
| :---: | :---: |
| Internal Power Dissipation . . . . . . . . . . . . . . . . . 500 mW |  |
| Input Voltage | $\pm 18 \mathrm{~V}^{2}$ |
| Output Short Circuit Duration . . . . . . . . . . . . . . Indefin |  |
| Differential Input Voltage |  |
| Storage Temperature Range (H) . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |  |
| Operating Temperature Range |  |
| AD549J, K, L | 0 to $+70^{\circ} \mathrm{C}$ |
| AD549S | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Lead Temperature Range (Sold | $+300^{\circ} \mathrm{C}$ |

Internal Power Dissipation . . . . . . . . . . . . . . . . . . 500 mW
Input Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 18 \mathrm{~V}^{2}$
Output Short Circuit Duration . . . . . . . . . . . . . . . Indefinite
Differential Input Voltage . . . . . . . . . . . . . $+V_{\text {S }}$ and $-V_{S}$
Storage Temperature Range (H) . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Operating Temperature Range

## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ For supply voltages less than $\pm 18 \mathrm{~V}$, the absolute maximum input voltage is equal to the supply voltage.

## METALIZATION PHOTOGRAPH

Dimensions shown in inches and (mm).
Contact factory for latest dimensions.


## CAUTION:

ESD (electrostatic discharge) sensitive device. Charges as high as 4000 V readily accumulate on the human body and test equipment and discharge without detection. Therefore, reasonable ESD precautions are recommended to avoid functional damage or performance degradation. Unused devices should be stored in conductive foam or shunts, and the foam should be discharged to the destination socket before devices are removed. For further information on ESD precautions, refer
 to Analog Devices' ESD Prevention Manual.

Dual, Low Cost, Precision BiFET Operational Amplifiers AD642/AD644/AD647

## FEATURES

Matched Offset Voltage
Matched Offset Voltage over Temperature
Matched Bias Current
Crosstalk: -124 dB @ 1 kHz
Low Bias Current: 35 pA max (Warmed Up)
Low Offset Voltage: $\mathbf{2 5 0} \mu \mathrm{V}$ max (AD647L)
Low Input Voltage Noise: $2.0 \mu \mathrm{~V}$ p-p
High Slew Rate: $13 \mathrm{~V} / \mu \mathrm{s}$ (AD644)
Low Quiescent Current
Low Total Harmonic Distortion (0.0015\%-AD644)
Standard Dual Amplifier Pin-out
MIL-STD-883B Versions Available
Single Versions Offered: AD542, AD544, AD547

## PRODUCT DESCRIPTION

The AD642/AD644/AD647 series of precision, monolithic FET-input op amps are pairs of matched, high speed, BiFET op amps fabricated with the most advanced BiFET and laser trimming technologies. The AD642, AD644, AD647 series offers matched bias currents significantly lower than currently available dual, BiFET devices, 35 pA max., warmed up. In addition, the offset voltage is laser trimmed to less than 0.25 mV on the AD647L, using Analog Devices' laser wafer trimming (LWT) process.
This product series achieves tight matching and temperature tracking between the amplifiers by using the most advanced ionimplantation and laser wafer drift trimming technologies. Ionimplantation permits the fabrication of precision, matched JFETs on a monolithic bipolar chip. This process optimizes the ability to produce matched amplifiers which have lower initial bias currents than other popular BiFET amplifiers. Laser wafer trimming each amplifier's input offset voltage ensures tight initial match, and combined with superior wafer processing guarantees offset tracking over the temperature range.
The AD642, AD644 and AD647 are recommended for applications requiring excellent ac and dc performance. The matched amplifiers provide a low cost solution for true instrumentation amplifiers, low drift active filters, log ratio amplifiers, and output amplifiers for four quadrant multiplying D/A converters, such as the AD7541, 12-bit CMOS DAC.
Devices in this series are available in four grades: the " J ," " K ," and "L" grades are specified over the $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ temperature range and the " S " grade over the $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ operating temperature range. All devices are offered in the hermetically sealed, TO-99 metal can package. In addition, the AD647 is also offered in a 20 -pin, hermetic, surface mount LCC package.

CONNECTION DIAGRAMS


## PRODUCT HIGHLIGHTS

1. Tight matching specifications ensure high performance and eliminate the need to match individual devices.
2. Analog Devices, unlike some manufacturers, specifies each device for the maximum bias current at either input in the warmed-up condition, thus assuring the user that the device will meet its published specifications in actual use.
3. Advanced laser wafer trimming techniques reduce offset voltage to only 0.25 mV max and matched side to side to 0.25 mV (AD647L), thus eliminating the need for external nulling.
4. Low voltage noise ( $2 \mu \mathrm{~V} p-\mathrm{p}$ ) and high open-loop gain enhance performance as a precision op amp.
5. High slew rate ( $13 \mathrm{~V} / \mu \mathrm{s}$ ) and fast settling time to $0.01 \%$ $(3.0 \mu \mathrm{~s})$ make the AD644 ideal for D/A, A/D, sample-hold circuits and high speed integrators.
6. Low harmonic distortion ( $0.0015 \%$ ) and low crosstalk $(-124 \mathrm{~dB})$ make the AD644 an ideal choice in stereo audio applications
7. Bare die are available for use in hybrid circuit applications.

## 

| Parameter | AD642 |  |  | AD644 |  |  | AD647 |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| OPEN-LOOP GAIN |  |  |  |  |  |  |  |  |  |  |
| $\mathrm{V}_{\text {OUT }}= \pm 10 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ |  |  |  |  |  |  |  |  |  |  |
| $J$ Grade | 100 |  |  | 30 |  |  | 100 |  |  | $\mathrm{V} / \mathrm{mV}$ |
| K, L, S Grades | 250 |  |  | 50 |  |  | 250 |  |  | $\mathrm{V} / \mathrm{mV}$ |
| $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\mathrm{MAX}}, \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ |  |  |  |  |  |  |  |  |  |  |
| J Grade | 100 |  |  | 20 |  |  | 100 |  |  | $\mathrm{V} / \mathrm{mV}$ |
| K, L Grades | 250 |  |  | 40 |  |  | 250 |  |  | $\mathrm{V} / \mathrm{mV}$ |
| S Grade | 100 |  |  | 20 |  |  | 100 |  |  | $\mathrm{V} / \mathrm{mV}$ |
| OUTPUT CHARACTERISTICS |  |  |  |  |  |  |  |  |  |  |
| $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ |  |  |  |  |  |  |  |  |  |  |
| $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ | $\pm 10$ | $\pm 12$ |  | $\pm 10$ | $\pm 12$ |  | $\pm 10$ | $\pm 12$ |  | V |
| $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ |  |  |  |  |  |  |  |  |  |  |
| $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ | $\pm 12$ | $\pm 13$ |  | $\pm 12$ | $\pm 13$ |  | $\pm 12$ | $\pm 13$ |  | V |
| Short Circuit Current |  | 25 |  |  | 25 |  |  | 25 |  | mA |
| FREQUENCY RESPONSE |  |  |  |  |  |  |  |  |  |  |
| Unity Gain, Small Signal |  | 1.0 |  |  | 2.0 |  |  | 1.0 |  | MHz |
| Full Power Response |  | 50 |  |  | 200 |  |  | 50 |  | kHz |
| Slew Rate, Unity Gain | 2.0 | 3.0 |  | 8.0 | 13.0 |  | 2.0 | 3.0 |  | V/ $/ \mathrm{s}$ |
| Total Harmonic Distortion |  |  |  |  | 0.0015 |  |  |  |  | \% |
| INPUT OFFSET VOLTAGE ${ }^{1}$ |  |  |  |  |  |  |  |  |  |  |
| Initial Offset |  |  |  |  |  |  |  |  |  |  |
| J Grade |  |  | 2.0 |  |  | 2.0 |  |  | 1.0 | mV |
| K Grade |  |  | 1.0 |  |  | 1.0 |  |  | 0.5 | mV |
| L Grade |  |  | 0.5 |  |  | 0.5 |  |  | 0.25 | mV |
| S Grade |  |  | 1.0 |  |  | 1.0 |  |  | 0.5 | mV |
|  |  |  |  |  |  |  |  |  |  |  |
| J Grade |  |  | 3.5 |  |  | 3.5 |  |  | 1.5 | mV |
| K Grade |  |  | 2.0 |  |  | 2.0 |  |  | 1.0 | mV |
| L Grade |  |  | 1.0 |  |  | 1.0 |  |  | 0.5 | mV |
| S Grade |  |  | 3.5 |  |  | 3.5 |  |  | 1.5 | mV |
| vs. Supply, $\mathrm{T}_{\text {A }}=\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |  |  |  |  |  |  |  |  |  |  |
| J Grade |  |  | 200 |  |  | 200 |  |  | 200 | $\mu \mathrm{V} / \mathrm{V}$ |
| K, L, S Grades |  |  | 100 |  |  | 100 |  |  | 100 | $\mu \mathrm{V} / \mathrm{V}$ |
| INPUT BIAS CURRENT ${ }^{2}$ |  |  |  |  |  |  |  |  |  |  |
| Either Input |  |  |  |  |  |  |  |  |  |  |
| J Grade |  | 10 | 75 |  | 10 | 75 |  | 10 | 75 | pA |
| K, L, S Grades |  | 10 | 35 |  | 10 | 35 |  | 10 | 35 | pA |
| Input Offset Current |  |  |  |  |  |  |  |  |  |  |
| J Grade |  | 5 |  |  | 10 |  |  | 5 |  | pA |
| K, L, S Grades |  | 2 |  |  | 5 |  |  | 2 |  | pA |
| MATCHING CHARACTERISTICS ${ }^{3}$ |  |  |  |  |  |  |  |  |  |  |
| Input Offset Voltage |  |  |  |  |  |  |  |  |  |  |
| J Grade |  |  | 1.0 |  |  | 1.0 |  |  | 1.0 | mV |
| K Grade |  |  | 0.5 |  |  | 0.5 |  |  | 0.5 | mV |
| L Grade |  |  | 0.25 |  |  | 0.25 |  |  | 0.25 | mV |
| S Grade |  |  | 0.5 |  |  | 0.5 |  |  | 0.5 | mV |
| Input Offset Voltage, $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |  |  |  |  |  |  |  |  |  |  |
| J Grade |  |  | 3.5 |  |  | 3.5 |  |  | 1.5 | mV |
| K Grade |  |  | 2.0 |  |  | 2.0 |  |  | 1.0 | mV |
| L Grade |  |  | 1.0 |  |  | 1.0 |  |  | 0.5 | mV |
| S Grade |  |  | 3.5 |  |  | 3.5 |  |  | 1.5 | mV |
| Input Bias Current |  |  |  |  |  |  |  |  |  |  |
| J, S Grades |  |  | 35 |  |  | 35 |  |  | 35 | pA |
| K, L Grades |  |  | 25 |  |  | 25 |  |  | 25 | pA |
| Crosstalk |  | -124 |  |  | -124 |  |  | -124 |  | dB |



## NOTES

${ }^{1}$ Input Offset Voltage specifications are guaranteed after 5 minutes of operation at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.
${ }^{2}$ Bias Current specifications are guaranteed at either input after 5 minutes of operation at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. For higher temperatures, the current doubles every $10^{\circ} \mathrm{C}$.
${ }^{3}$ Matching is defined as the difference between parameters of the two amplifiers.
${ }^{4}$ Defined as the maximum safe voltage between inputs, such that neither exceeds $\pm 10 \mathrm{~V}$ from ground.
Specifications subject to change without notice.
Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels.
All $\min$ and max specifications are guaranteed, although only those shown in boldface are tested on all production units.

## ORDERING GUIDE

| Model | Package Description | Package Option^ |  | Model | Package Description | Package Option* |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| AD642JCHIPS | Bare Die |  |  | AD647JCHIPS | Bare Die |  |
| AD642JH | 8-Pin Hermetic Metal Can | H-08A |  | AD647JH | 8-Pin Hermetic Metal Can | H-08A |
| AD642KH | 8-Pin Hermetic Metal Can | H-08A |  | AD647KH | 8-Pin Hermetic Metal Can | H-08A |
| AD642LH | 8-Pin Hermetic Metal Can | H-08A |  | AD647LH | 8-Pin Hermetic Metal Can | H-08A |
| AD642SH | 8-Pin Hermetic Metal Can | H-08A |  | AD647SE | 20-Pin Hermetic LCC | E-20A |
| AD642SH/883B | 8-Pin Hermetic Metal Can | H-08A |  | AD647SE/883B | 20-Pin Hermetic LCC | E-20A |
| AD644JH | 8-Pin Hermetic Metal Can | H-08A |  | AD647SH | 8-Pin Hermetic Metal Can | H-08A |
| AD644KH | 8-Pin Hermetic Metal Can | H-08A |  | AD647SH/883B | 8-Pin Hermetic Metal Can | H-08A |
| AD644LH | 8-Pin Hermetic Metal Can | H-08A |  | *For outline information see Package Information section. |  |  |
| AD644SCHIPS | Bare Die |  |  |  |  |  |
| AD644SH | 8-Pin Hermetic Metal Can | H-08A |  |  |  |  |
| AD644SH/883B | 8-Pin Hermetic Metal Can | H-08A |  |  |  |  |

## FEATURES

Improved Replacement for Burr-Brown
OPA-111 and OPA-121 Op Amp
LOW NOISE
$2 \mu \mathrm{~V}$ p-p max, 0.1 Hz to 10 Hz
$10 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ max at 10 kHz
11 fA p-p Current Noise 0.1 Hz to 10 Hz
HIGH DC ACCURACY
$250 \mu \mathrm{~V}$ max Offset Voltage
$1 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ max Drift
1.5 pA max Input Bias Current

114 dB Open-Loop Gain
Available in Plastic Mini-DIP, 8-Pin Header Packages, or Chip Form

## APPLICATIONS

Low Noise Photodiode Preamps
CT Scanners
Precision I-V Converters

## PRODUCT DESCRIPTION

The AD645 is a low noise, precision FET input op amp. It offers the pico amp level input currents of a FET input device coupled with offset drift and input voltage noise comparable to a high performance bipolar input amplifier.
The AD645 has been improved to offer the lowest offset drift in a FET op amp, $1 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$. Offset voltage drift is measured and trimmed at wafer level for the lowest cost possible. An inherently low noise architecture and advanced manufacturing techniques result in a device with a guaranteed low input voltage noise of $2 \mu \mathrm{~V}$ p-p, 0.1 Hz to 10 Hz . This level of dc performance along with low input currents make the AD645 an excellent choice for high impedance applications where stability is of prime concern.


Figure 1. AD645 Voltage Noise Spectral Density vs. Frequency

## CONNECTION DIAGRAMS



TO-99 (H) Package


NOTE: CASE IS CONNECTED TO PIN 8

The AD645 is available in six performance grades. The AD645J and AD645K are rated over the commercial temperature range of $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$. The AD645A, AD645B, and the ultraprecision AD645C are rated over the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$. The AD645S is rated over the military temperature range of $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ and is available processed to MIL-STD-883B.
The AD645 is available in an 8-pin plastic mini-DIP, 8 -pin header, or in die form.

## PRODUCT HIGHLIGHTS

1. Guaranteed and tested low frequency noise of $2 \mu \mathrm{~V}$ p-p max and $20 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ at 100 Hz makes the AD645C ideal for low noise applications where a FET input op amp is needed.
2. Low $\mathrm{V}_{\mathrm{Os}}$ drift of $1 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ max makes the AD645C an excellent choice for applications requiring ultimate stability.
3. Low input bias current and current noise ( $11 \mathrm{fA} \mathrm{p}-\mathrm{p} 0.1 \mathrm{~Hz}$ to 10 Hz ) allow the AD645 to be used as a high precision preamp for current output sensors such as photodiodes, or as a buffer for high source impedance voltage output sensors.


Figure 2. Typical Distribution of Average Input Offset Voltage Drift (196 Units)

| Model | Conditions | AD645J/A |  |  | AD645K/B |  |  | AD645C |  |  | AD645S |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| INPUT OFFSET VOLTAGE ${ }^{1}$ <br> Initial Offset <br> Offset <br> Drift (Average) <br> vs. Supply (PSRR) <br> vs. Supply | $\begin{aligned} & \mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }} \\ & \mathrm{T}_{\mathrm{MIN}}-\mathrm{T}_{\mathrm{MAX}} \end{aligned}$ | 90 | $\begin{aligned} & 100 \\ & 300 \\ & 3 \\ & 110 \\ & 100 \\ & \hline \end{aligned}$ | $\begin{aligned} & 500 \\ & 1000 \\ & 10 / 5 \end{aligned}$ | 94 90 | $\begin{aligned} & 50 \\ & 100 \\ & 1 \\ & 110 \\ & 100 \\ & \hline \end{aligned}$ | $\begin{aligned} & 250 \\ & 400 \\ & 5 / 2 \end{aligned}$ | 94 90 | $\begin{aligned} & 50 \\ & 75 \\ & 0.5 \\ & 110 \\ & 100 \\ & \hline \end{aligned}$ | $\begin{aligned} & 250 \\ & 300 \end{aligned}$ | $\begin{array}{\|l} 90 \\ 86 \\ \hline \end{array}$ | $\begin{aligned} & 100 \\ & 500 \\ & 4 \\ & 110 \\ & 95 \end{aligned}$ | $\begin{aligned} & 500 \\ & 1500 \\ & 10 \end{aligned}$ | $\mu \mathrm{V}$ <br> $\mu \mathrm{V}$ <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ <br> dB <br> dB |
| INPUT BIAS CURRENT ${ }^{2}$ <br> Either Input <br> Either Input <br> @ $\mathrm{T}_{\mathrm{MAX}}$ <br> Either Input <br> Offset Current <br> Offset Current <br> @ $\mathrm{T}_{\text {max }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CM}}=+10 \mathrm{~V} \\ & \mathrm{v}_{\mathrm{CM}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V} \\ & \hline \end{aligned}$ |  | $\begin{aligned} & 0.7 / 1.8 \\ & 16 / 115 \\ & 0.8 / 1.9 \\ & 0.1 \\ & \\ & 2 / 6 \\ & \hline \end{aligned}$ | $3 / 5$ 1.0 |  | $\begin{aligned} & 0.7 / 1.8 \\ & 16 / 115 \\ & 0.8 / 1.9 \\ & 0.1 \\ & \\ & 2 / 6 \\ & \hline \end{aligned}$ | $1.5 / 3$ 0.5 |  | $\begin{aligned} & 1.8 \\ & 115 \\ & 1.9 \\ & 0.1 \end{aligned}$ | 0.5 |  | $\begin{aligned} & 1.8 \\ & 1800 \\ & 1.9 \\ & 0.1 \\ & \\ & 100 \\ & \hline \end{aligned}$ | 1.0 | pA <br> pA <br> pA <br> pA <br> pA |
| INPUT VOLTAGE NOISE | $\begin{aligned} & 0.1 \text { to } 10 \mathrm{~Hz} \\ & \mathrm{f}=10 \mathrm{~Hz} \\ & \mathrm{f}=100 \mathrm{~Hz} \\ & \mathrm{f}=1 \mathrm{kHz} \\ & \mathrm{f}=10 \mathrm{kHz} \end{aligned}$ |  | $\begin{aligned} & 1.0 \\ & 20 \\ & 10 \\ & 9 \\ & 8 \end{aligned}$ | $\begin{aligned} & 3.0 \\ & 50 \\ & 30 \\ & 15 \\ & 10 \end{aligned}$ |  | $\begin{aligned} & 1.0 \\ & 20 \\ & 10 \\ & 9 \\ & 8 \end{aligned}$ | $\begin{aligned} & 2.5 \\ & 40 \\ & 20 \\ & 12 \\ & 10 \end{aligned}$ |  | $\begin{aligned} & 1 \\ & 20 \\ & 10 \\ & 9 \\ & 8 \end{aligned}$ | $\begin{aligned} & \hline 2 \\ & 40 \\ & 20 \\ & 12 \\ & 10 \end{aligned}$ |  | $\begin{aligned} & 1.0 \\ & 20 \\ & 10 \\ & 9 \\ & 8 \end{aligned}$ | $\begin{aligned} & 3.3 \\ & 50 \\ & 30 \\ & 15 \\ & 10 \end{aligned}$ | $\mu \mathrm{V}$ p-p <br> $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ <br> $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ <br> $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ <br> $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| INPUT CURRENT NOISE | $\begin{array}{\|l\|} \hline \mathrm{f}=0.1 \text { to } 10 \mathrm{~Hz} \\ \mathrm{f}=0.1 \text { thru } 20 \mathrm{kHz} \end{array}$ |  | $\begin{aligned} & \hline 11 \\ & 0.6 \end{aligned}$ | $\begin{aligned} & 20 \\ & 1.1 \end{aligned}$ |  | $\begin{aligned} & 11 \\ & 0.6 \end{aligned}$ | $\begin{aligned} & 15 \\ & 0.8 \end{aligned}$ |  | $\begin{aligned} & 11 \\ & 0.6 \end{aligned}$ | $\begin{aligned} & \hline 15 \\ & 0.8 \end{aligned}$ |  | $\begin{aligned} & 11 \\ & 0.6 \end{aligned}$ | $\begin{aligned} & 20 \\ & 1.1 \end{aligned}$ | $\begin{aligned} & \text { fA p-p } \\ & \text { fA } / \sqrt{\mathrm{Hz}} \end{aligned}$ |
| FREQUENCY RESPONSE <br> Unity Gain, Small Signal Full Power Response Slew Rate, Unity Gain | $\begin{aligned} & \mathrm{V}_{\mathrm{O}}=20 \mathrm{~V} \mathrm{p}-\mathrm{p} \\ & \mathrm{R}_{\text {LOAD }}=2 \mathrm{k} \Omega \\ & \mathrm{~V}_{\text {OUT }}=20 \mathrm{Vpp} \mathrm{p} \\ & \mathrm{R}_{\text {LOAD }}=2 \mathrm{k} \Omega \end{aligned}$ |  | $\begin{aligned} & 2 \\ & 32 \\ & 2 \end{aligned}$ |  |  | $\begin{aligned} & 2 \\ & 32 \\ & 2 \end{aligned}$ |  |  | 32 2 |  |  | 2 32 2 |  | MHz <br> kHz <br> $\mathrm{V} / \mathrm{us}$ |
| SETTLING TIME ${ }^{3}$ <br> To 0.1\% <br> To 0.01\% Overload Recovery ${ }^{4}$ Total Harmonic Distortion | $\begin{aligned} & 50 \% \text { Overdrive } \\ & \mathrm{f}=1 \mathrm{kHz} \\ & \mathrm{R}_{\mathrm{LOAD}} \geq 2 \mathrm{k} \Omega \\ & \mathrm{~V}_{\mathrm{O}}=3 \mathrm{~V} \mathrm{rms} \end{aligned}$ |  | $\begin{aligned} & 6 \\ & 8 \\ & 5 \\ & \\ & 0.0006 \end{aligned}$ |  |  | $\begin{aligned} & 6 \\ & 8 \\ & 5 \\ & 0.0006 \end{aligned}$ |  |  | $\begin{aligned} & 6 \\ & 8 \\ & 5 \\ & \\ & 0.000 \end{aligned}$ |  |  | $\begin{aligned} & 6 \\ & 8 \\ & 5 \\ & \\ & 0.000 \end{aligned}$ |  | $\mu \mathrm{s}$ $\mu \mathrm{s}$ <br> $\mu \mathrm{s}$ <br> \% |
| INPUT IMPEDANCE <br> Differential Common-Mode | $\mathrm{V}_{\text {DIFF }}= \pm 1 \mathrm{~V}$ | $\begin{aligned} & 10^{12} \\| 1 \\ & 10^{14}\| \| 2.2 \\ & \hline \end{aligned}$ |  |  | $\begin{aligned} & 10^{12} \\| 1 \\ & 10^{14} \\| 2.2 \\ & \hline \end{aligned}$ |  |  | $\begin{aligned} & 10^{12\| \| \mid} \\ & 10^{14}\| \| 2.2 \end{aligned}$ |  |  | $\begin{aligned} & 10^{12} \\| 1 \\ & 10^{14} \\| 2.2 \end{aligned}$ |  |  | $\begin{aligned} & \Omega \\| \mathrm{pF} \\ & \Omega \\| \mathrm{pF} \end{aligned}$ |
| INPUT VOLTAGE RANGE Differential ${ }^{5}$ Common-Mode Voltage Over Max Oper. Range Common-Mode Rejection Ratio | $\begin{aligned} & \mathrm{V}_{\mathrm{CM}}= \pm 10 \mathrm{~V} \\ & \mathrm{~T}_{\mathrm{MIN}}-\mathrm{T}_{\mathrm{MAX}} \end{aligned}$ | $\begin{aligned} & \pm 10 \\ & \pm 10 \\ & 90 \end{aligned}$ | $\begin{aligned} & \pm 20 \\ & +11,- \\ & 110 \\ & 100 \end{aligned}$ |  | $\begin{aligned} & \pm 10 \\ & \pm 10 \\ & 94 \\ & 90 \end{aligned}$ | $\begin{aligned} & \pm 20 \\ & +11,- \\ & 110 \\ & 100 \end{aligned}$ |  | $\begin{aligned} & \pm 10 \\ & \pm 10 \\ & \\ & 94 \\ & 90 \end{aligned}$ | $\begin{aligned} & \pm 20 \\ & +11, \\ & 110 \\ & 100 \end{aligned}$ |  | $\begin{aligned} & \pm 10 \\ & \pm 10 \\ & 90 \\ & 86 \end{aligned}$ | $\begin{aligned} & \pm 20 \\ & +11, \\ & 110 \\ & 100 \end{aligned}$ |  | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \end{aligned}$ |
| OPEN-LOOP GAIN | $\begin{aligned} & \mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{LOAD}} \geq 2 \mathrm{k} \Omega \\ & \mathrm{~T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }} \\ & \hline \end{aligned}$ | 114 | 130 |  | $\begin{aligned} & 120 \\ & 114 \\ & \hline \end{aligned}$ | 130 |  | $\begin{aligned} & 120 \\ & 114 \\ & \hline \end{aligned}$ | 130 |  | $\begin{aligned} & 114 \\ & 110 \\ & \hline \end{aligned}$ | 130 |  | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \end{aligned}$ |
| OUTPUT CHARACTERISTICS <br> Voltage <br> Current | $\begin{aligned} & \mathrm{R}_{\text {LOAD }} \geq 2 \mathrm{k} \Omega \\ & \mathrm{~T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }} \\ & \mathrm{V}_{\text {OUT }}= \pm 10 \mathrm{~V} \\ & \text { Short Circuit } \end{aligned}$ | $\begin{aligned} & \pm 10 \\ & \pm 10 \\ & \pm 5 \end{aligned}$ | $\begin{aligned} & \pm 11 \\ & \pm 10 \\ & \pm 15 \end{aligned}$ |  | $\begin{aligned} & \pm 10 \\ & \pm 10 \\ & \pm 5 \end{aligned}$ | $\begin{aligned} & \pm 11 \\ & \pm 10 \\ & \pm 15 \end{aligned}$ |  | $\begin{aligned} & \pm 10 \\ & \pm 10 \\ & \pm 5 \end{aligned}$ | $\begin{aligned} & \pm 11 \\ & \pm 10 \\ & \pm 15 \end{aligned}$ |  | $\begin{aligned} & \pm 10 \\ & \pm 10 \\ & \pm 5 \end{aligned}$ | $\begin{aligned} & \pm 11 \\ & \pm 10 \\ & \pm 15 \end{aligned}$ |  | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~mA} \\ & \mathrm{~mA} \end{aligned}$ |
| POWER SUPPLY <br> Rated Performance Operating Range Quiescent Current Transistor Count | \# of Transistors | $\pm 5$ | $\begin{aligned} & \pm 15 \\ & 3.0 \\ & 62 \end{aligned}$ | $\begin{aligned} & \pm 18 \\ & 3.5 \end{aligned}$ | $\pm 5$ | $\begin{aligned} & \pm 15 \\ & 3.0 \\ & 62 \end{aligned}$ | $\begin{aligned} & \pm 18 \\ & 3.5 \end{aligned}$ | $\pm 5$ | $\begin{aligned} & \pm 15 \\ & 3.0 \\ & 62 \end{aligned}$ | $\begin{aligned} & \pm 18 \\ & 3.5 \end{aligned}$ | $\pm 5$ | $\begin{aligned} & \pm 15 \\ & 3.0 \\ & 62 \end{aligned}$ | $\begin{aligned} & \pm 18 \\ & 3.5 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~mA} \end{aligned}$ |

[^130]${ }^{2}$ Bias current specifications are guaranteed maximum at either input after 5 minutes of operation at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. For higher temperature, the current doubles every $10^{\circ} \mathrm{C}$.
${ }^{3}$ Gain $=-1, R_{\text {LOAD }}=2 \mathrm{k} \Omega$.
${ }^{4}$ Defined as the time required for the amplifier's output to return to normal operation after removal of a $50 \%$ overload from the amplifier input.
${ }^{5}$ Defined as the maximum continuous voltage between the inputs such that neither input exceeds $\pm 10 \mathrm{~V}$ from ground.
All min and max specifications are guaranteed.
Specifications subject to change without notice.

| ABSOLUTE MAXIMUM RATINGS ${ }^{1}$ |  |
| :---: | :---: |
| Supply Voltage . . . . . . . . . | V |
| Internal Power Dissipation ${ }^{2}\left(@ \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right)$ |  |
| 8-Pin Header Package . . . . . . . . . . . . . . . . . . 500 mW |  |
| 8-Pin Mini-DIP Package | 750 mW |
| Input Voltage . . . . . . . . . . . . . . . . . . . . . . . . . $\pm \mathrm{V}_{\text {s }}$ |  |
| Output Short Circuit Duration . . . . . . . . . . . . . . Indefinite |  |
| Differential Input Voltage . . . . . . . . . . . . $+\mathrm{V}_{\text {s }}$ and $-\mathrm{V}_{\text {s }}$ |  |
| Storage Temperature Range (H) . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |  |
| Storage Temperature Range (N) . . . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  |
| Operating Temperature Range |  |
| AD645J/K | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ |
| AD645A/B/C | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |

AD645S . . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Lead Temperature Range
(Soldering 60 seconds)
. $300^{\circ} \mathrm{C}$

## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ Thermal Characteristics:
8-Pin Plastic Mini-DIP Package: $\theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} /$ Watt
8 -Pin Header Package: $\theta_{\mathrm{JA}}=200^{\circ} \mathrm{C} /$ Watt

CAUTION
ESD (electrostatic discharge) sensitive device. Charges as high as 4000 V readily accumulate on the human body and test equipment and discharge without detection. Therefore, reasonable ESD precautions are recommended to avoid functional damage or performance degradation. Unused devices should be stored in conductive foam or shunts, and the foam should be discharged to the destination socket before devices are removed. For further information on ESD
 precautions, refer to Analog Devices' ESD Prevention Manual.

ORDERING GUIDE

| Model ${ }^{\mathbf{1}}$ | Temperature <br> Range | Package <br> Option |
| :--- | :--- | :--- |
| AD645JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| AD645KN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | N-8 |
| AD645AH | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{H}-08 \mathrm{~A}$ |
| AD645BH | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{H}-08 \mathrm{~A}$ |
| AD645CH | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{H}-08 \mathrm{~A}$ |
| AD645SH/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{H}-08 \mathrm{~A}$ |

NOTES
${ }^{1}$ Chips are also available.
${ }^{2} \mathrm{~N}=$ Plastic mini-DIP; H = Metal Can. For outline information see Package Information section.


METALIZATION PHOTOGRAPH
Dimensions shown in inches and (mm).
Contact factory for latest dimensions.


Figure 3. AD645 Offset Null Configuration


Figure 4. Typical Distribution of Input Offset Voltage (1855 Units)


Figure 5. Typical Distribution of Input Bias Current (576 Units)


Figure 6. Typical Distribution of 0.1 Hz to 10 Hz Voltage Noise (202 Units)
of 0 to $+70^{\circ} \mathrm{C}$. The AD648A, AD648B and AD648C are rated over the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. The AD648S and AD648T are rated over the military temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ and are available processed to MIL-STD-883B, Rev. C.
The AD648 is available in an 8-pin plastic mini-DIP, cerdip, SOIC, TO-99 metal can, or in chip form.

## PRODUCT HIGHLIGHTS

1. A combination of low supply current, excellent dc and ac performance and low drift makes the AD648 the ideal op amp for high performance, low power applications.
2. The AD648 is pin compatible with industry standard dual op amps such as the LF442, TL062, and AD642, enabling designers to improve performance while achieving a reduction in power dissipation of up to $85 \%$.
3. Guaranteed low input offset voltage ( 2 mV max) and drift ( $20 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ max) for the AD648J are achieved utilizing Analog Devices' laser drift trimming technology.
4. Analog Devices specifies each device in the warmed-up condition, insuring that the device will meet its published specifications in actual use.
5. Matching characteristics are excellent for all grades. The input offset voltage matching between amplifiers in the AD648J is within 2 mV , for the C grade matching is within 0.4 mV .
6. Crosstalk between amplifiers is less than -120 dB at 1 kHz .
7. The AD648 is available in chip form.

## PRODUCT DESCRIPTION

The AD648 is a matched pair of low power, precision monolithic operational amplifiers. It offers both low bias current ( 10 pA max, warmed up) and low quiescent current ( $400 \mu \mathrm{~A}$ $\max$ ) and is fabricated with ion-implanted FET and laser wafer trimming technologies. Input bias current is guaranteed over the AD648's entire common-mode voltage range.
The economical J grade has a maximum guaranteed offset voltage of less than 2 mV and an offset voltage drift of less than $20 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$. The C grade reduces offset voltage to less than 0.30 mV and offset voltage drift to less than $3 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$. This level of dc precision is achieved utilizing Analog's laser wafer drift trimming process. The combination of low quiescent current and low offset voltage drift minimizes changes in input offset voltage due to self-heating effects. Five additional grades are offered over the commercial, industrial and military temperature ranges.
The AD648 is recommended for any dual supply op amp application requiring low power and excellent dc and ac performance. In applications such as battery-powered, precision instrument front ends and CMOS DAC buffers, the AD648's excellent combination of low input offset voltage and drift, low bias current and low $1 / \mathrm{f}$ noise reduces output errors. High common-mode rejection ( $86 \mathrm{~dB}, \min$ on the "C" grade) and high open-loop gain ensures better than 12-bit linearity in high impedance, buffer applications.

The AD648 is pinned out in a standard dual op amp configuration and is available in seven performance grades. The AD648J and AD648K are rated over the commercial temperature range

AD648-SPECIFICATIONS
(@ $+25^{\circ} \mathrm{C}$ and $\mathrm{V}_{\mathrm{s}}= \pm 15 \mathrm{~V}$ dc, unless otherwise noted)

| Model | Min | AD648J/ Typ | Max | Min | $\begin{gathered} \text { AD648K/E } \\ \text { Typ } \end{gathered}$ | Max | Min | AD648 <br> Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT OFFSET VOLTAGE ${ }^{1}$ <br> Initial Offset $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ vs. Temp. vs. Supply vs. Supply, $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ Long-Term Offset Stability | $\begin{aligned} & 80 \\ & 76 / 76 / 76 \end{aligned}$ | $0.75$ | $\begin{aligned} & 2.0 \\ & 3.0 / 3.0 / 3.0 \\ & 20 \end{aligned}$ | $\begin{aligned} & 86 \\ & 80 \end{aligned}$ | $0.3$ $15$ | $\begin{aligned} & 1.0 \\ & 1.5 / 1.5 / 2.0 \end{aligned}$ | $\begin{aligned} & 86 \\ & 80 \end{aligned}$ | $0.10$ $15$ | $\begin{aligned} & 0.3 \\ & 0.5 \\ & 3.0 \end{aligned}$ | $\begin{aligned} & \mathrm{mV} \\ & \mathrm{mV} \\ & \mu \mathrm{~V} /{ }^{\circ} \mathrm{C} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \\ & \mu \mathrm{~V} / \text { month } \end{aligned}$ |
| INPUT BIAS CURRENT <br> Either Input, ${ }^{2} V_{C M}=0$ <br> Either Input ${ }^{2}$ at $\mathrm{T}_{\text {max }}, \mathrm{V}_{\mathrm{CM}}=0$ Max Input Bias Current Over Common-Mode Voltage Range Offset Current, $\mathrm{V}_{\mathrm{CM}}=0$ Offset Current at $\mathrm{T}_{\text {max }}$ |  | 5 | $\begin{aligned} & 20 \\ & 0.45 / 1.3 / 20 \\ & \\ & 30 \\ & 10 \\ & 0.25 / 0.7 / 10 \end{aligned}$ |  | $2$ | $\begin{aligned} & 10 \\ & 0.25 / 0.65 / 10 \\ & 15 \\ & 5 \\ & 0.15 / 0.35 / 5 \end{aligned}$ |  | $3$ <br> 2 | $\begin{aligned} & 10 \\ & 0.65 \\ & \\ & 15 \\ & 5 \\ & 0.35 \end{aligned}$ | pA <br> nA <br> pA <br> pA <br> nA |
| MATCHING CHARACTERISTICS ${ }^{3}$ <br> Input Offset Voltage <br> Input Offset Voltage $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ <br> Input Offset Voltage vs. Temp <br> Input Bias Current <br> Crosstalk |  | $\begin{aligned} & 1.0 \\ & 8 \\ & -120 \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 3.0 / 3.0 / 3.0 \end{aligned}$ $10$ |  | $\begin{aligned} & 0.5 \\ & 5 \\ & -120 \end{aligned}$ | $\begin{aligned} & 1.0 \\ & 1.5 / 1.5 / 2.0 \end{aligned}$ <br> 5 |  | $\begin{aligned} & 0.2 \\ & 2.5 \\ & -120 \end{aligned}$ | $\begin{aligned} & 0.4 \\ & 0.5 \\ & 5 \end{aligned}$ | $\begin{aligned} & \mathrm{mV} \\ & \mathrm{mV} \\ & \mu \mathrm{~V} /{ }^{\circ} \mathrm{C} \\ & \mathrm{pA} \\ & \mathrm{~dB} \end{aligned}$ |
| $\begin{aligned} & \text { INPUT IMPEDANCE } \\ & \text { Differential } \\ & \text { Common Mode } \end{aligned}$ |  | $\begin{aligned} & 1 \times 10^{12} \\| 3 \\ & 3 \times 10^{12} \\| 3 \end{aligned}$ |  |  |  |  |  | $\begin{aligned} & 1 \times 10^{12} \\| 3 \\ & 3 \times 10^{12} \\| 3 \end{aligned}$ |  | $\begin{aligned} & \Omega \\| \mathrm{pF} \\ & \Omega \\| \mathrm{pF} \end{aligned}$ |
| ```INPUT VOLTAGE RANGE Differential \({ }^{4}\) Common Mode Common-Mode Rejection \(\mathrm{V}_{\mathrm{CM}}= \pm 10 \mathrm{~V}\) \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) \(\mathrm{V}_{\mathrm{CM}}= \pm 11 \mathrm{~V}\) \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\)``` | $\begin{aligned} & \pm 11 \\ & 76 \\ & 76 / 76 / 76 \\ & 70 \\ & 70 / 70 / 70 \end{aligned}$ | $\begin{aligned} & \pm 20 \\ & \pm 12 \end{aligned}$ |  | $\begin{aligned} & \pm 11 \\ & 82 \\ & 82 \\ & 76 \\ & 76 \end{aligned}$ | $\begin{aligned} & \pm 20 \\ & \pm 12 \end{aligned}$ |  | $\begin{aligned} & \pm 11 \\ & \\ & 86 \\ & 86 \\ & 76 \\ & 76 \end{aligned}$ | $\begin{aligned} & \pm 20 \\ & \pm 12 \end{aligned}$ |  | V <br> V <br> dB <br> dB <br> dB <br> dB |
| $\begin{aligned} & \hline \text { INPUT VOLTAGE NOISE } \\ & \text { Voltage } 0.1 \mathrm{~Hz} \text { to } 10 \mathrm{~Hz} \\ & \mathrm{f}=10 \mathrm{~Hz} \\ & \mathrm{f}=100 \mathrm{~Hz} \\ & \mathrm{f}=1 \mathrm{kHz} \\ & \mathrm{f}=10 \mathrm{kHz} \end{aligned}$ |  | $\begin{aligned} & 2 \\ & 80 \\ & 40 \\ & 30 \\ & 30 \end{aligned}$ |  |  | $\begin{aligned} & 2 \\ & 80 \\ & 40 \\ & 30 \\ & 30 \end{aligned}$ |  |  | $\begin{aligned} & 2 \\ & 80 \\ & 40 \\ & 30 \\ & 30 \end{aligned}$ | 4.0 | $\mu \mathrm{V}$ p-p <br> $\mathrm{nV} / \mathrm{Hz}$ <br> $\mathrm{nV} / \overline{\mathrm{Hz}}$ <br> $\mathrm{nV} / \overline{\mathrm{Hz}}$ <br> $\mathrm{nV} / \overline{\mathrm{Hz}}$ |
| INPUT CURRENT NOISE $\mathrm{f}=1 \mathrm{kHz}$ |  | 1.8 |  |  | 1.8 |  |  | 1.8 |  | $\mathrm{fA} / \overline{\mathrm{Hz}}$ |
| FREQUENCY RESPONSE <br> Unity Gain, Small Signal <br> Full Power Response <br> Slew Rate, Unity Gain <br> Settling Time to $\pm 0.01 \%$ | $\begin{aligned} & 0.8 \\ & 1.0 \end{aligned}$ | $\begin{aligned} & 1.0 \\ & 30 \\ & 1.8 \\ & 8 \end{aligned}$ |  | $\begin{aligned} & 0.8 \\ & 1.0 \end{aligned}$ | $\begin{aligned} & 1.0 \\ & 30 \\ & 1.8 \\ & 8 \end{aligned}$ |  |  | $\begin{aligned} & 1.0 \\ & 30 \\ & 1.8 \\ & 8 \end{aligned}$ |  | MHz <br> kHz <br> V/ $\mu \mathrm{s}$ <br> $\mu \mathrm{s}$ |
| $\begin{aligned} & \text { OPEN-LOOP GAIN } \\ & \mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V}, \mathrm{R}_{\mathrm{L}} \geq 10 \mathrm{k} \Omega \\ & \mathrm{~T}_{\min } \text { to } \mathrm{T}_{\max }, \mathrm{R}_{\mathrm{L}} \geq 10 \mathrm{k} \Omega \\ & \mathrm{~V}_{\mathrm{O}}= \pm 10 \mathrm{~V}, \mathrm{R}_{\mathrm{L}} \geq 5 \mathrm{k} \Omega \\ & \mathrm{~T}_{\min } \text { to } \mathrm{T}_{\max }, \mathrm{R}_{\mathrm{L}} \geq 5 \mathrm{k} \Omega \end{aligned}$ | $\begin{aligned} & 300 \\ & 300 / 300 / 300 \\ & 150 \\ & 150 / 150 / 150 \end{aligned}$ | $\begin{aligned} & 1000 \\ & 700 \\ & 500 \\ & 300 \end{aligned}$ |  | $\begin{aligned} & 300 \\ & 300 \\ & 150 \\ & 150 \end{aligned}$ | $\begin{aligned} & 1000 \\ & 700 \\ & 500 \\ & 300 \end{aligned}$ | . | $\begin{aligned} & 300 \\ & 300 \\ & 150 \\ & 150 \end{aligned}$ | $\begin{aligned} & 1000 \\ & 700 \\ & 500 \\ & 300 \end{aligned}$ |  | V/mV <br> $\mathrm{V} / \mathrm{mV}$ <br> $\mathrm{V} / \mathrm{mV}$ <br> $\mathrm{V} / \mathrm{mV}$ |
| $\begin{aligned} & \text { OUTPUT CHARACTERISTICS } \\ & \text { Voltage @ } \mathrm{R}_{\mathrm{L}} \geq 10 \mathrm{k} \Omega \text {, } \\ & \mathrm{T}_{\min } \text { to } \mathrm{T}_{\max } \\ & \text { Voltage } @ \mathrm{R}_{\mathrm{L}} \geq 5 \mathrm{k} \Omega \text {, } \\ & \mathrm{T}_{\min } \text { to } \mathrm{T}_{\max } \\ & \text { Short Circuit Current } \end{aligned}$ | $\begin{aligned} & \pm 12 / \pm 12 / \pm 12 \\ & \pm 11 / \pm 11 / \pm 11 \end{aligned}$ | $\begin{aligned} & \pm 13 \\ & \pm 12 \\ & 15 \end{aligned}$ |  | $\begin{aligned} & \pm 12 \\ & \pm 11 \end{aligned}$ | $\begin{aligned} & \pm 13 \\ & \pm 12 \\ & 15 \end{aligned}$ | - | $\begin{aligned} & \pm 12 \\ & \pm 11 \end{aligned}$ | $\begin{aligned} & \pm 13 \\ & \pm 12 \\ & 15 \end{aligned}$ |  | V <br> V <br> mA |
| POWER SUPPLY Rated Performance Operating Range Quiescent Current (Both Amplifiers) | $\pm 4.5$ | $\begin{aligned} & \pm 15 \\ & 340 \end{aligned}$ | $\begin{aligned} & \pm 18 \\ & 400 \end{aligned}$ | $\pm 4.5$ | $\begin{aligned} & \pm 15 \\ & 340 \end{aligned}$ | $\begin{aligned} & \pm 18 \\ & 400 \end{aligned}$ | $\pm 4.5$ | $\begin{aligned} & \pm 15 \\ & 340 \end{aligned}$ | $\begin{aligned} & \pm 18 \\ & 400 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mu \mathrm{~A} \end{aligned}$ |
| TEMPERATURE RANGE Operating, Rated Performance Commercial ( 0 to $+70^{\circ} \mathrm{C}$ ) Industrial $\left(-40^{\circ} \mathrm{C}\right.$ to $\left.+85^{\circ} \mathrm{C}\right)$ Military $\left(-55^{\circ} \mathrm{C}\right.$ to $+125^{\circ} \mathrm{C}$ ) | - | AD648 AD648 AD648 |  |  | AD648K <br> AD648B <br> AD648T |  |  | AD648C |  |  |
| PACKAGE OPTIONS SOIC (R-8) Plastic (N-8) Cerdip (Q-8) Metal Can (H-08A) Tape and Reel Chips Available | AD648AQ, A | AD648JR AD648JN 648SQ, AD648AF 648JR-RE hips, AD | 648SQ/883B | AD64 | $\begin{array}{r} \text { AD64 } \\ \text { AD64 } \\ \text { Q, AD648T } \\ \text { 648BH, AI } \\ \text { AD648K } \end{array}$ | AD648TQ/883B <br> 7TH/883B <br> EEL |  | AD64 |  |  |

NOTES
${ }^{1}$ Input Offset Voltage specifications are guaranteed after 5 minutes of operation at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.
${ }^{2}$ Bias Current specifications are guaranteed maximum at either input after 5 minutes of operation at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. For higher temperature, the current doubles every $10^{\circ} \mathrm{C}$.
${ }^{3}$ Matching is defined as the difference between parameters of the two amplifiers.
${ }^{4}$ Defined as voltages between inputs, such that neither exceeds $\pm 10 \mathrm{~V}$ from ground.
${ }^{5}$ For outline information see Package Information section.
Specifications subject to change without notice.

ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

| Supply Voltage | $\pm 18 \mathrm{~V}$ |
| :---: | :---: |
| Internal Power Dissipation ${ }^{2}$ | 500 mW |
| Input Voltage ${ }^{3}$ | $\pm 18 \mathrm{~V}$ |
| Output Short Circuit Duration | Indefinite |
| Differential Input Voltage | $+\mathrm{V}_{\mathrm{S}}$ and $-\mathrm{V}_{\text {S }}$ |
| Storage Temperature Range (Q, H) | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| ( $\mathrm{N}, \mathrm{R}$ ) | $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Operating Temperature Range |  |
| AD648J/K | 0 to $+70^{\circ} \mathrm{C}$ |
| AD648A/B/C | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| AD648S/T | $55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
|  | 300 |

NOTES
${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ Thermal Characteristics
8-Pin Plastic DIP Package: $\quad \theta_{\mathrm{JA}}=165^{\circ} \mathrm{C} /$ Watt 8-Pin Cerdip Package: $\quad \theta_{\mathrm{JC}}=22^{\circ} \mathrm{C} /$ Watt; $\theta_{\mathrm{JA}}=110^{\circ} \mathrm{C} / \mathrm{Watt}$ 8 -Pin Metal Can Package: $\theta_{\mathrm{JC}}=65^{\circ} \mathrm{C} /$ Watt; $\theta_{\mathrm{JA}}=150^{\circ} \mathrm{C} / \mathrm{Watt}$ 8-Pin SOIC Package: $\quad \theta_{\mathrm{JC}}=42^{\circ} \mathrm{C} / \mathrm{Watt} ; \theta_{\mathrm{JA}}=160^{\circ} \mathrm{C} / \mathrm{Watt}$
${ }^{3}$ For supply voltages less than $\pm 18 \mathrm{~V}$, the absolute maximum input voltage is equal to the supply voltage.

## METALIZATION PHOTOGRAPH

Contact factory for latest dimensions.
Dimensions shown in inches and (mm).


# Picoampere Input Current, Bipolar Operational Amplifiers AD704/AD705/AD706 

FEATURES
HIGH DC PRECISION
Low Offset Voltage
( $75 \mu \mathrm{~V}$ max: AD704)
(35 $\mu \mathrm{V}$ max: AD705)
( $50 \mu \mathrm{~V}$ max: AD706)

## Low Offset Drift

( $1.0 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ max: AD704)
( $0.6 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ max: AD705)
( $0.6 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ max: AD706)
Low Input Bias Currents
(150 pA max: AD704)
(100 pA max: AD705)
(110 pA max: AD706)
LOW NOISE
$0.5 \mu \mathrm{~V}$ p-p typ Voltage Noise ( 0.1 Hz to 10 Hz )
LOW POWER
$600 \mu$ A max Supply Current per Amplifier
AC PERFORMANCE
$0.15 \mathrm{~V} / \mu \mathrm{s}$ Slew Rate
800 kHz Unity Gain Crossover Frequency
10,000 pF Capacitive Load Drive Capability
LOW COST
MIL-STD-883B Versions Available (Single or Quad)
Single: AD705
Dual: AD706
Quad: AD704

## APPLICATIONS

Industrial/Process Controls
Weigh Scales
Medical Instrumentation (ECG/EKG)
Low Frequency Active Filters
Precision Integrators

## PRODUCT DESCRIPTION

The AD704/AD705/AD706 series are low power, bipolar op amps that have the low input bias current of BiFET amplifiers, but offer a significantly lower $\mathrm{I}_{\mathrm{B}}$ drift over temperature. This series offers many of the advantages of BiFET and bipolar op amps without their inherent disadvantages. They utilize superbeta bipolar input transistors to achieve the picoampere input bias current levels of FET input amplifiers (at room temperature), while their $\mathrm{I}_{\mathrm{B}}$ typically increases 5 times vs. BiFET amplifiers which exhibit a $1000 \times$ increase over temperature. Superbeta bipolar technology also permits these amplifiers to achieve the microvolt offset voltages and low noise characteristics of a precision bipolar input amplifier.

Since these amplifiers have only $1 / 20$ of the input bias current of an industry standard OP07, the AD704/AD705/AD706 do not require the commonly used "balancing" resistor. Furthermore, the current noise is $1 / 5$ that of the OP07, which makes these

## FUNCTIONAL BLOCK DIAGRAMS



NC $=$ NO CONNECT
amplifiers usable with much higher source impedances. At $1 / 6$ the supply current (per amplifier) of the OP07, these amplifiers are better suited for today's higher density systems and battery powered applications.

The AD704, AD705 and AD706 are excellent choices for use in low frequency active filters for 12 - and 14 -bit data acquisition systems, in precision instrumentation, and as high quality integrators. These amplifiers are internally compensated for unity gain and are available in various performance grades. The "J" and " K " grades are rated over the commercial temperature range of $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$. The " A " and " B " grades are rated over the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. The " T " grade is rated over the military temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. Select versions are available processed to MIL-STD883B, Rev. C.

SPEGIFIGATIONS $\left(V_{C M}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V}\right.$ @ $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)


| Parameter | Conditions | Model | Min | $\begin{aligned} & \text { J/A } \\ & \text { Typ } \end{aligned}$ | Max | Min | K/B/S <br> Typ | Max | Min | $\begin{aligned} & \mathbf{C / T} \\ & \mathrm{Typ} \end{aligned}$ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT OFFSET VOLTAGE UNITY GAIN Crossover Frequency Slew Rate | $\begin{aligned} & \mathrm{G}=-1 \\ & \mathrm{~T}_{\mathrm{MIN}} \text { to } \mathrm{T}_{\mathrm{MAX}} \end{aligned}$ | All <br> All <br> All |  | $\begin{aligned} & 0.8 \\ & 0.15 \\ & 0.15 \end{aligned}$ |  |  | $\begin{aligned} & 0.8 \\ & 0.15 \\ & 0.15 \end{aligned}$ |  |  | $\begin{aligned} & 0.8 \\ & 0.15 \\ & 0.15 \end{aligned}$ |  | MHz <br> $\mathrm{V} / \mu \mathrm{s}$ <br> $\mathrm{V} / \mu \mathrm{s}$ |
| INPUT IMPEDANCE Differential Common Mode |  | $\begin{aligned} & \text { All } \\ & \text { All } \end{aligned}$ |  | $\begin{aligned} & 40 \\| 2 \\ & 300 \\| 2 \end{aligned}$ |  |  | $\begin{aligned} & 40 \\| 2 \\ & 300\|\mid 2 \end{aligned}$ |  |  | $\begin{aligned} & 40 \\| 2 \\ & 300 \\| 2 \end{aligned}$ |  | $\begin{aligned} & \mathrm{M} \Omega \\| \mathrm{pF} \\ & \mathrm{G} \Omega \\| \mathrm{pF} \end{aligned}$ |
| INPUT VOLTAGE RANGE Common-Mode Voltage Common-Mode Rejection Ratio | $\begin{aligned} & \mathrm{V}_{\mathrm{CM}}= \pm 13.5 \mathrm{~V} \\ & \mathrm{~T}_{\mathrm{MIN}} \text { to } \mathrm{T}_{\mathrm{MAX}} \end{aligned}$ | All <br> AD704 <br> AD705 <br> AD706 <br> AD704 <br> AD705 <br> AD706 | $\begin{aligned} & \pm 13.5 \\ & 100 \\ & 110 \\ & 110 \\ & 98 \\ & 108 \\ & 108 \end{aligned}$ | $\begin{aligned} & \pm 14 \\ & 132 \\ & 132 \\ & 132 \\ & 128 \\ & 128 \\ & 128 \end{aligned}$ |  | $\begin{aligned} & \pm 13.5 \\ & 114 \\ & 114 \\ & 114 \\ & 108 \\ & 108 \\ & 108 \end{aligned}$ | $\begin{aligned} & \pm 14 \\ & 132 \\ & 132 \\ & 132 \\ & 128 \\ & 128 \\ & 128 \end{aligned}$ |  | $\begin{aligned} & \pm 13.5 \\ & 110 \\ & 114 \\ & 114 \\ & 108 \\ & 108 \\ & 108 \end{aligned}$ | $\begin{aligned} & \pm 14 \\ & 132 \\ & 132 \\ & 132 \\ & 128 \\ & 128 \\ & 128 \end{aligned}$ |  | V <br> dB <br> dB <br> dB <br> dB <br> dB <br> dB |
| INPUT CURRENT NOISE | $\begin{aligned} & 0.1 \mathrm{~Hz} \text { to } 10 \mathrm{~Hz} \\ & \mathrm{f}=10 \mathrm{~Hz} \end{aligned}$ | $\begin{aligned} & \text { All } \\ & \text { All } \end{aligned}$ |  | $\begin{aligned} & 3 \\ & 50 \end{aligned}$ |  |  | $\begin{aligned} & 3 \\ & 50 \end{aligned}$ |  |  | $\begin{aligned} & 3 \\ & 50 \end{aligned}$ |  | pA p-p $\mathrm{fA} / \sqrt{\mathrm{Hz}}$ |
| INPUT VOLTAGE NOISE | $\begin{aligned} & 0.1 \mathrm{~Hz} \text { to } 10 \mathrm{~Hz} \\ & \mathrm{f}=10 \mathrm{~Hz} \\ & \mathrm{f}=1 \mathrm{kHz} \end{aligned}$ | AD704 <br> AD705/6 <br> All <br> All |  | $\begin{aligned} & 0.5 \\ & 0.5 \\ & 17 \\ & 15 \end{aligned}$ | 22 |  | $\begin{aligned} & 0.5 \\ & 0.5 \\ & 17 \\ & 15 \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 1.0 \\ & 22 \end{aligned}$ |  | $\begin{aligned} & 0.5 \\ & 0.5 \\ & 17 \\ & 15 \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 1.0 \\ & 22 \end{aligned}$ | $\mu \mathrm{V}$ p-p <br> $\mu \mathrm{V}$ p-p <br> $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ <br> $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| OPEN LOOP GAIN | $\begin{aligned} & \mathrm{V}_{\mathrm{O}}= \pm 12 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \\ & \mathrm{~T}_{\text {MIN }} \text { to } \mathrm{T}_{\text {MAX }} \\ & \mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & \mathrm{~T}_{\text {MIN }} \text { to } \mathrm{T}_{\text {MAX }} \end{aligned}$ | All <br> All <br> All <br> All | $\begin{aligned} & 200 \\ & 150 \\ & \\ & 200 \\ & 150 \end{aligned}$ | $\begin{aligned} & 2000 \\ & 1500 \\ & \\ & 1000 \\ & 1000 \end{aligned}$ |  | $\begin{array}{r} 400 \\ 300 \\ 300 \\ 200 \end{array}$ | $\begin{aligned} & 2000 \\ & 1500 \\ & \\ & 1000 \\ & 1000 \end{aligned}$ |  | $\begin{aligned} & 400 \\ & 300 \\ & \\ & 200 \\ & 100 \end{aligned}$ | $\begin{aligned} & 2000 \\ & 1500 \\ & \\ & 1000 \\ & 1000 \end{aligned}$ |  | $\begin{aligned} & \mathrm{V} / \mathrm{mV} \\ & \mathrm{~V} / \mathrm{mV} \\ & \mathrm{~V} / \mathrm{mV} \\ & \mathrm{~V} / \mathrm{mV} \end{aligned}$ |
| OUTPUT CHARACTERISTICS <br> Voltage Swing, $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ <br> Current <br> Capacitive Load Drive | $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ Short Circuit $\mathrm{G}=+1$ | $\begin{aligned} & \text { All } \\ & \text { All } \\ & \text { All } \end{aligned}$ | $\pm 13$ | $\begin{aligned} & \pm 14 \\ & \pm 15 \\ & 10,000 \end{aligned}$ |  | $\pm 13$ | $\begin{aligned} & \pm 14 \\ & \pm 15 \\ & 10,000 \end{aligned}$ |  | $\pm 13$ | $\begin{aligned} & \pm 14 \\ & \pm 15 \\ & 10,000 \end{aligned}$ |  | V <br> mA <br> pF |
| POWER SUPPLY <br> Rated Performance Operating Range Quiescent Current | $\mathrm{T}_{\mathrm{MIN}}$ to $\mathrm{T}_{\mathrm{MAX}}$ | All <br> All <br> AD704 <br> AD705 <br> AD706 <br> AD704 <br> AD705 <br> AD706 | $\pm 2$ | $\begin{aligned} & \pm 15 \\ & \\ & 1.5 \\ & 0.38 \\ & 0.75 \\ & 1.6 \\ & 0.4 \\ & 0.8 \end{aligned}$ | $\begin{aligned} & \pm 18 \\ & 2.4 \\ & 0.6 \\ & 1.2 \\ & 2.6 \\ & 0.8 \\ & 1.4 \end{aligned}$ | $\pm 2$ | $\begin{aligned} & \\ & 1.5 \\ & 0.38 \\ & 0.75 \\ & 1.6 \\ & 0.4 \\ & 0.8 \end{aligned}$ | $\begin{aligned} & \pm 15 \\ & \pm 18 \\ & 2.4 \\ & 0.6 \\ & 1.2 \\ & 2.6 \\ & 0.8 \\ & 1.4 \end{aligned}$ | $\pm 2$ | $\begin{aligned} & \pm 15 \\ & \\ & 1.5 \\ & 0.38 \\ & 0.75 \\ & 1.6 \\ & 0.4 \\ & 0.8 \end{aligned}$ | $\begin{aligned} & \pm 18 \\ & 2.4 \\ & 0.6 \\ & 1.2 \\ & 2.6 \\ & 0.8 \\ & 1.4 \end{aligned}$ | V <br> V <br> mA <br> mA <br> mA <br> mA <br> mA <br> mA |
| TRANSISTOR COUNT | \# of Transistors | AD704 AD705 AD706 |  | $\begin{aligned} & 180 \\ & 45 \\ & 90 \end{aligned}$ |  |  | $\begin{aligned} & 180 \\ & 45 \\ & 90 \end{aligned}$ |  |  | $\begin{aligned} & 180 \\ & 45 \\ & 90 \end{aligned}$ |  |  |

## NOTES

${ }^{1}$ Bias current specifications are guaranteed maximum at either input.
${ }^{2}$ Input bias current match is the maximum difference between corresponding inputs of all amplifiers on the chip.
${ }^{3} \mathrm{CMRR}$ match is the difference of $\Delta \mathrm{V}_{\mathrm{OS}} / \Delta \mathrm{V}_{\mathrm{CM}}$ between any two amplifiers.
${ }^{4} \mathrm{PSRR}$ match is the difference between $\Delta \mathrm{V}_{\mathrm{os}} / \Delta \mathrm{V}$ SUPPLY for any two amplifiers.
Specifications subject to change without notice.

| ABSOLUTE MAXIMUM RATINGS ${ }^{1}$ |  |
| :---: | :---: |
| Supply Voltage | 8 V |
| Internal Power Dissipation ${ }^{2}$ | 650 mW |
| Input Voltage | $\pm \mathrm{V}_{\text {S }}$ |
| Differential Input Voltage ${ }^{3}$ | $\pm 0.7 \mathrm{~V}$ |
| Output Short Circuit Duration | Indefinite |
| Storage Temperature Range (N, R) | $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Storage Temperature Range (Q, H) | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Operating Temperature Range |  |
| AD70xJ/K | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ |
| AD70xA/B | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| AD70xS/T | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Lead Temperature Range (Soldering | $+300^{\circ} \mathrm{C}$ |

NOTES
'Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ Specification is for device in free air:
8-Pin Plastic Package: $\quad \theta_{\mathrm{JA}}=165^{\circ} \mathrm{C} / \mathrm{Watt}$
8-Pin Cerdip Package: $\quad \theta_{\mathrm{JA}}=110^{\circ} \mathrm{C} / \mathrm{Watt}$
8 -Pin Small Outline Package: $\theta_{\mathrm{JA}}=155^{\circ} \mathrm{C} / \mathrm{Watt}$
14-Pin Plastic Package: $\quad \theta_{\mathrm{JA}}=150^{\circ} \mathrm{C} / \mathrm{Watt}$
14-Pin Cerdip Package: $\quad \theta_{\mathrm{JA}}=110^{\circ} \mathrm{C} / \mathrm{Watt}$ 16-Pin SOIC Package: $\quad \theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} / \mathrm{Watt}$ 20-Terminal LCC Package: $\quad \theta_{\mathrm{JA}}=150^{\circ} \mathrm{C} / \mathrm{Watt}$
${ }^{3}$ The input pins of these amplifiers are protected by back-to-back diodes. If the differential voltage exceeds $\pm 0.7 \mathrm{~V}$, external series protection resistors should be added to limit the input current to less than 25 mA .

## ORDERING GUIDE

| Model | Temperature Range | Package Description | Package Option ${ }^{\star}$ |
| :---: | :---: | :---: | :---: |
| AD704AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 14-Pin Plastic DIP | N-14 |
| AD704AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 14-Pin Ceramic DIP | Q-14 |
| AD704AR-16 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 16-Pin Plastic SOIC | R-16 |
| AD704AR-16-REEL | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 16-Pin Plastic SOIC | R-16 |
| AD704AR-16-REEL7 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 16-Pin Plastic SOIC | R-16 |
| AD704BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 14-Pin Ceramic DIP | Q-14 |
| AD704JCHIPS | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Bare Die |  |
| AD704JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 14-Pin Plastic DIP | N-14 |
| AD704JR-16 | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 16-Pin Plastic SOIC | R-16 |
| AD704JR-16-REEL | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 16-Pin Plastic SOIC | R-16 |
| AD704JR-16-REEL7 | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 16-Pin Plastic SOIC | R-16 |
| AD704KN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 14-Pin Plastic DIP | N-14 |
| AD704SE/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 20-Pin Ceramic LCC | E-20A |
| AD704TQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 14-Pin Ceramic DIP | Q-14 |
| AD704TQ/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 14-Pin Ceramic DIP | Q-14 |
| AD705AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Ceramic DIP | Q-8 |
| AD705BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8 -Pin Ceramic DIP | Q-8 |
| AD705JCHIPS | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Bare Die |  |
| AD705JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | N-8 |
| AD705JR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | R-8 |
| AD705JR-REEL | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | R-8 |
| AD705JR-REEL7 | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | R-8 |
| AD705KN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | N-8 |
| AD705TQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Ceramic DIP | Q-8 |
| AD705TQ/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Ceramic DIP | Q-8 |
| AD706AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | N-8 |
| AD706AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Ceramic DIP | Q-8 |
| AD706AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | R-8 |
| AD706AR-REEL | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | R-8 |
| AD706AR-REEL7 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8 -Pin Plastic SOIC | R-8 |
| AD706BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Ceramic DIP | Q-8 |
| AD706JCHIPS | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Bare Die |  |
| AD706JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | N-8 |
| AD706JR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | R-8 |
| AD706JR-REEL | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | R-8 |
| AD706JR-REEL7 | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | R-8 |
| AD706KN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic | N-8 |

*For outline information see Package Information section.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although these devices feature proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

## FEATURES

Very High DC Precision
Low Offset Voltages
(15 $\mu \mathrm{V}$ max: AD707)
( $30 \mu \mathrm{~V}$ max: AD708)
Low Offset Drift
( $0.1 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ max: AD707)
( $0.3 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ max: AD708)
Low Input Bias Current: 1 nA max
Low Noise: $0.35 \mu \mathrm{~V}$ p-p $\max (0.1 \mathrm{~Hz}$ to 10 Hz )
130 dB min CMRR
120 dB min PSRR
AC Performance
0.3 V/ $\mu \mathrm{s}$ Slew Rate

900 kHz Closed-Loop Bandwidth
Matching Characteristics
$30 \mu \mathrm{~V}$ max Offset Voltage Match
$0.3 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ max Offset Drift Match
130 dB min CMRR Match
MIL-STD-883B Versions Available
Single: AD707
Dual: AD708

## PRODUCT DESCRIPTION

The AD707 (single) and AD708 (dual) are very high precision, monolithic operational amplifiers. Each device offers excellent dc precision with the best available max offset voltage and max offset voltage drift of any single/dual bipolar combination available.
The AD707 and AD708 set new standards for precision op amps by providing $5 \mathrm{~V} / \mu \mathrm{V}$ min open-loop gain and guaranteed max input voltage noise of 350 nV p-p ( 0.1 Hz to 10 Hz ). All dc specifications show excellent stability over temperature, with offset voltage drift typically $0.1 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ and input bias current drift of $25 \mathrm{pA} /{ }^{\circ} \mathrm{C}$ max. Both CMRR ( 130 dB max) and PSRR ( 120 dB max) are an order of magnitude improved over any available monolithic op amp.
The AD707 and AD708 are available in seven performance grades. The " J " and " K " grades are rated over the commercial temperature range of $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$. The " A ," " B " and " C " grades are rated over the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. The " S " and " T " grades are rated over the military temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. Select versions are also available processed to MIL-STD-883B, Rev. C.

FUNCTIONAL BLOCK DIAGRAMS


NC = NO CONNECT

## PRODUCT HIGHLIGHTS

1. The combination of outstanding matching and individual specifications make the AD707 and AD708 ideal for constructing high gain, precision instrumentation amplifiers.
2. The low offset voltage drift and low noise of the AD707 and AD708 allow the user to amplify very small signals without sacrificing overall system performance.
3. The AD707 and AD708 can be used where chopper amplifiers are required, but without the inherent noise and application problems.
4. The AD707 is an improved, pin-for-pin replacement for the LT1001, and the AD708 is an improved, pin-for-pin replacement for the LT1002.

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| Parameter | Conditions | Model | Min | $\begin{aligned} & \text { J/A } \\ & \text { Typ } \\ & \hline \end{aligned}$ | Max | Min | $\begin{aligned} & \text { K/B/S } \\ & \text { Typ } \end{aligned}$ | Max | Min | $\begin{aligned} & \text { C/T } \\ & \text { Typ } \end{aligned}$ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT RESISTANCE Differential Common Mode |  | $\begin{aligned} & \text { AD707 } \\ & \text { AD708 } \\ & \text { AD707 } \\ & \text { AD708 } \end{aligned}$ | 24 | $\begin{aligned} & 100 \\ & 60 \\ & 200 \\ & 200 \end{aligned}$ |  | 45 | $\begin{aligned} & 200 \\ & 200 \\ & 300 \\ & 400 \end{aligned}$ |  |  | $\begin{aligned} & 200 \\ & 400 \end{aligned}$ |  | $\mathrm{M} \Omega$ <br> $\mathrm{M} \Omega$ <br> G $\Omega$ <br> G $\Omega$ |
| OUTPUT CHARACTER Voltage | $\begin{aligned} & \mathrm{R}_{\mathrm{L}} \geq 10 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}} \geq 2 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}} \geq 1 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}} \geq 2 \mathrm{k} \Omega \end{aligned}$ <br> $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ | Both <br> Both <br> Both <br> Both | $\begin{aligned} & 13.5 \\ & 12.5 \\ & 12.0 \\ & 12.0 \end{aligned}$ | $\begin{aligned} & 14.0 \\ & 13.0 \\ & 12.5 \\ & 13.0 \end{aligned}$ |  | $\begin{aligned} & 13.5 \\ & 12.5 \\ & 12.0 \\ & 12.0 \end{aligned}$ | $\begin{aligned} & 14.0 \\ & 13.0 \\ & 12.5^{\circ} \\ & 13.0 \\ & \hline \end{aligned}$ |  | $\begin{aligned} & 13.5 \\ & 12.5 \\ & 12.0 \\ & 12.0 \end{aligned}$ | $\begin{aligned} & 14.0 \\ & 13.0 \\ & 12.5 \\ & 13.0 \\ & \hline \end{aligned}$ |  | $\begin{aligned} & \pm \mathrm{V} \\ & \pm \mathrm{V} \\ & \pm \mathrm{V} \\ & \pm \mathrm{V} \end{aligned}$ |
| OPEN-LOOP OUTPUT RESISTANCE |  | Both |  | 60 |  |  | 60 |  |  | 60 |  | $\Omega$ |
| POWER SUPPLY <br> Quiescent Current <br> Power Consumption, No Load | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 3 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & \text { AD707 } \\ & \text { AD708 } \\ & \text { AD707 } \\ & \text { AD708 } \\ & \text { AD707 } \\ & \text { AD708 } \\ & \text { Both } \end{aligned}$ | $\pm 3$ | $\begin{aligned} & 2.5 \\ & 4.5 \\ & 75 \\ & 135 \\ & 7.5 \\ & 12 \end{aligned}$ | $\begin{aligned} & 3.0 \\ & 5.5 \\ & 90 \\ & 165 \\ & 9.0 \\ & 18 \\ & \pm 18 \end{aligned}$ | $\pm 3$ | $\begin{aligned} & 2.5 \\ & 4.5 \\ & 75 \\ & 135 \\ & 7.5 \\ & 12 \end{aligned}$ | $\begin{aligned} & 3.0 \\ & 5.5 \\ & 90 \\ & 165 \\ & 9.0 \\ & 18 \\ & \pm 18 \end{aligned}$ | $\pm 3$ | 2.5 75 7.5 | 3.0 <br> 90 <br> 9.0 $\pm 18$ | mA <br> mA <br> mW <br> mW <br> mW <br> mW <br> V |

NOTES
${ }^{1}$ Input offset voltage specifications are guaranteed after 5 minutes of operation at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.
${ }^{2}$ Matching is defined as the difference between parameters of the two amplifiers.
All min and max specifications are guaranteed. Specifications in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

| Supply Voltage | $\pm 22 \mathrm{~V}$ |
| :---: | :---: |
| Internal Power Dissipation ${ }^{2}$ | 500 mW |
| Input Voltage | $\pm \mathrm{V}_{\text {S }}$ |
| Differential Input Voltage | $+\mathrm{V}_{S}$ and $-\mathrm{V}_{S}$ |
| Output Short Circuit Duration | Indefinite |
| Storage Temperature Range ( $\mathrm{N}, \mathrm{R}$ ) | $65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Storage Temperature Range (Q, H) | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Operating Temperature Range |  |

AD70xJ/K . . . . . . . . . . . . . . . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

AD70xA/B . . . . . . . . . . . . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
AD70xS/T . . . . . . . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Lead Temperature Range
(Soldering 60 sec )
$+300^{\circ} \mathrm{C}$

## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. ${ }^{2}$ Specification is for device in free air: 8 -pin plastic package, $\theta_{\mathrm{JA}}=165^{\circ} \mathrm{C} / \mathrm{Watt}$; 8 pin cerdip package, $\theta_{\mathrm{JA}}=110^{\circ} \mathrm{C} / \mathrm{Watt}$; 8 -pin small outline package, $\theta_{\mathrm{JA}}=155^{\circ} \mathrm{C} /$ Watt; 8-pin header package, $\theta_{\mathrm{JA}}=200^{\circ} \mathrm{C} / \mathrm{Watt}$.

## FEATURES

```
Enhanced Replacements for
    TL081; TL082; TL084
    LF411; LF412; LF347
```


## AC PERFORMANCE

Settles to $\pm 0.01 \%$ in $1.0 \mu \mathrm{~s}$
$16 \mathrm{~V} / \mu \mathrm{s}$ min Slew Rate
3 MHz min Unity Gain Bandwidth
$0.0003 \%$ Total Harmonic Distortion (THD)
DC PERFORMANCE
Low Offset Voltages
( 0.25 mV max-AD711C)
( 0.30 mV max-AD712C)
( 0.50 mV max-AD713K)
Low Offset Drift
( $3 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ max—AD711C)
( $5 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ max-AD712C)
$200 \mathrm{~V} / \mathrm{mV}$ min Open-Loop Gain
Low Noise ( 0.1 Hz to $\mathbf{1 0 ~ H z}$ )
( $4 \mu \mathrm{~V}$ p-p max-AD711C)
( $4 \mu \mathrm{~V}$ p-p max-AD712C)
MIL-STD-883B Versions Available
Single: AD711
Dual: AD712
Quad: AD713

## APPLICATIONS

Active Filters
Output Buffers for 12- and 14-Bit DACs
Input Buffers for Precision ADCs
Photo Diode Preamplifier Applications

## PRODUCT DESCRIPTION

The AD711/AD712/AD713 series are high speed, precision, monolithic operational amplifiers offering high performance at very modest prices. Their very low offset voltage and offset voltage drift are results of advanced laser wafer trimming technology. These benefits allow the user to easily upgrade existing designs that use older precision BiFETs and, in many cases, bipolar op amps.
The superior ac and dc performance of these op amps make them suitable for active filter designs. With a slew rate of $16 \mathrm{~V} / \mathrm{\mu}$ and settling times of $1 \mu$ s to $0.01 \%$, the AD711/AD712/AD713 series is ideal for use as buffers for 12 -bit $\mathrm{D} / \mathrm{A}$ and $\mathrm{A} / \mathrm{D}$ converters and as high speed integrators. The settling time is unmatched by any similar IC amplifier. The combination of excellent noise performance and low input current also make these amplifiers useful for photo diode preamplifiers. Common-mode rejection of 88 dB and open loop gain of $400 \mathrm{~V} / \mathrm{mV}$ insure 12-bit performance even in high speed, unity gain, buffer circuits. These amplifiers are pinned out in standard op amp configurations and are available in various performance grades. The " J " and " K " grades are rated over the commercial temperature range of $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$. The "A," "B," and "C" grades are rated over the

[^132]
## CONNECTION DIAGRAMS



NOTE: PIN 4 CONNECTED TO CASE


NOTE: PIN 4 CONNECTED TO CASE


NC $=$ NO CONNECT
industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. The " S " and " T " grades are rated over the military temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. Select versions are available processed to MIL-STD-883B, Rev. C or Standard Military Drawings.

## PRODUCT HIGHLIGHTS

1. The AD711/AD712/AD713 series offers excellent overall performance at competitive prices.
2. Analog Devices' advanced processing technology and $100 \%$ testing guarantees a low input offset voltage ( 0.25 mV max $A D 711 \mathrm{C} ; 0.30 \mathrm{mV}$ max AD 712 C ). Input offset voltages are specified in the warmed up condition. Analog Devices' laser wafer drift trimming process reduces input offset voltage drifts to $3 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}(\mathrm{AD} 711 \mathrm{C})$ or $5 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}(\mathrm{AD} 712 \mathrm{C})$.
3. Along with precision dc performance, the AD711, AD712 and AD713 offer excellent dynamic response. They settle to $\pm 0.01 \%$ in $1 \mu \mathrm{~s}$ and have a $100 \%$ tested minimum slew rate of $16 \mathrm{~V} / \mu \mathrm{s}$. This makes these parts ideal for DAC and ADC buffers, which require a combination of superior ac and dc performance.
4. Analog Devices' well matched, ion-implanted JFETs ensure low input bias currents and low input offset currents. Both input bias and offset currents are guaranteed in the warmedup condition.

## AD711/AD712/AD713-SPECIFICATIONS

AD711 ${\left(v_{S}= \pm 15\right.}^{\left.\mathrm{V} @ \mathrm{I}_{A}=+25^{\circ} \mathrm{C} \text { unless otherwise noted) }\right) ~}$


## NOTES

${ }^{1}$ Input Offset Voltage specifications are guaranteed after 5 minutes of operation at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.
${ }^{2}$ Bias Current specifications are guaranteed maximum at either input after 5 minutes of operation at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. For higher temperatures, the current doubles every $10^{\circ} \mathrm{C}$. ${ }^{3}$ Defined as voltage between inputs, such that neither exceeds $\pm 10 \mathrm{~V}$ from ground.
${ }^{4}$ Typically exceeding -14.1 V negative common-mode voltage on either input results in an output phase reversal.
Specifications subject to change without notice.
$\left(V_{S}= \pm 15 \mathrm{~V} @ \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right.$ unless otherwise noted)


## NOTES

${ }^{1}$ Input Offset Voltage specifications are guaranteed after 5 minutes of operation at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.
${ }^{2}$ Bias Current specifications are guaranteed maximum at either input after 5 minutes of operation at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. For higher temperatures, the current doubles every $10^{\circ} \mathrm{C}$.
${ }^{3}$ Defined as voltage between inputs, such that neither exceeds $\pm 10 \mathrm{~V}$ from ground.
${ }^{4}$ Typically exceeding -14.1 V negative common-mode voltage on either input results in an output phase reversal.
Specifications subject to change without notice.

## AD711/AD712/AD713-SPECIFICATIONS

AD713 $\left(\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V} @ \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right.$ unless otherwise noted)

| Parameter | Conditions | Min | J/A/S <br> Typ | Max | Min | $\begin{aligned} & \mathrm{K} / \mathrm{B} / \mathrm{T} \\ & \mathrm{Typ} \end{aligned}$ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT OFFSET VOLTAGE ${ }^{1}$ <br> Initial Offset <br> Offset <br> vs. Temp <br> vs. Supply <br> vs. Supply <br> Long-Term Stability <br> Month | $\begin{aligned} & \mathrm{T}_{\text {MIN }} \text { to } \mathrm{T}_{\mathrm{MAX}} \\ & \mathrm{~T}_{\text {MIN }} \text { to } \mathrm{T}_{\mathrm{MAX}} \end{aligned}$ | $78$ $76 / 76 / 76$ | $\begin{aligned} & 0.3 \\ & 0.5 \\ & 5 \\ & 95 \\ & 95 \\ & 15 \end{aligned}$ | $\begin{aligned} & 1.5 \\ & 2 / 2 / 2 \end{aligned}$ | 84 | $\begin{aligned} & 0.2 \\ & 0.4 \\ & 5 \\ & 100 \\ & 100 \\ & 15 \end{aligned}$ | $\begin{aligned} & 0.5 \\ & 0.7 / 0.7 / 1.0 \\ & 20 / 20 / 15 \end{aligned}$ | $\begin{aligned} & \mathrm{mV} \\ & \mathrm{mV} \\ & \mu \mathrm{~V} /{ }^{\circ} \mathrm{C} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \\ & \mu \mathrm{~V} / \end{aligned}$ |
| INPUT BIAS CURRENT ${ }^{2}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V} @ \mathrm{~T}_{\mathrm{MAX}} \\ & \mathrm{~V}_{\mathrm{CM}}= \pm 10 \mathrm{~V} \\ & \hline \end{aligned}$ |  | $\begin{array}{r} 40 \\ 55 \\ \hline \end{array}$ | $\begin{aligned} & 150 \\ & 3.4 / 9.6 / 154 \\ & 200 \end{aligned}$ |  | $\begin{array}{r}40 \\ 55 \\ \hline\end{array}$ | $\begin{aligned} & 75 \\ & 1.7 / 4.8 / 77 \\ & 120 \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{pA} \\ & \mathrm{nA} \\ & \mathrm{pA} \end{aligned}$ |
| INPUT OFFSET CURRENT | $\begin{aligned} & \mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V} @ \mathrm{~T}_{\mathrm{MAX}} \\ & \hline \end{aligned}$ |  | 10 | $\begin{aligned} & 75 \\ & 1.7 / 4.8 / 77 \end{aligned}$ |  | 10 | $\begin{aligned} & 35 \\ & 0.8 / 2.2 / 36 \end{aligned}$ | $\mathrm{pA}$ |
| MATCHING CHARACTERISTICS <br> Input Offset Voltage Input Offset Voltage Input Offset Voltage Drift Input Bias Current Crosstalk | $\mathrm{T}_{\mathrm{MIN}} \text { to } \mathrm{T}_{\mathrm{MAX}}$ $\begin{aligned} & \mathrm{f}=1 \mathrm{kHz} \\ & \mathrm{f}=100 \mathrm{kHz} \end{aligned}$ |  | $\begin{aligned} & 0.5 \\ & 0.7 \\ & 8 \\ & 10 \end{aligned}$ | $\begin{aligned} & 1.8 \\ & 2.3 / 2.3 / 2.3 \\ & \\ & 100 \\ & -130 \\ & -95 \\ & \hline \end{aligned}$ |  | $\begin{aligned} & 0.4 \\ & 0.6 \\ & 6 \\ & 10 \end{aligned}$ | $\begin{aligned} & \mathbf{0 . 8} \\ & \mathbf{1 . 0} / \mathbf{1 . 0} / 1.3 \\ & 25 \\ & \mathbf{3 5} \\ & -130 \\ & -95 \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{mV} \\ & \mathrm{mV} \\ & \mu \mathrm{~V} /{ }^{\circ} \mathrm{C} \\ & \mathrm{pA} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \\ & \hline \end{aligned}$ |
| FREQUENCY RESPONSE <br> Small Signal Bandwidth <br> Full Power Response <br> Slew Rate <br> Settling Time to $0.01 \%$ Total Harmonic Distortion | Unity Gain $\mathrm{V}_{\mathrm{O}}=20 \mathrm{~V} \mathrm{p}-\mathrm{p}$ <br> Unity Gain $\begin{aligned} & \mathrm{f}=1 \mathrm{kHz} ; \mathrm{R}_{\mathrm{L}} \geq 2 \mathrm{k} \Omega ; \\ & \mathrm{V}_{\mathrm{O}}=3 \mathrm{~V} \mathrm{rms} \end{aligned}$ | $\begin{array}{ll} 3.0 & 4 \\ & 2 \\ 16 & 2 \\ & 1 \\ & 0 \end{array}$ | $\begin{aligned} & 4.0 \\ & 200 \\ & 20 \\ & 1.0 \\ & 0.0003 \end{aligned}$ | 1.2 | $\begin{aligned} & 3.4 \\ & 18 \end{aligned}$ | $\begin{aligned} & 4.0 \\ & 200 \\ & 20 \\ & 1.0 \\ & 0.0003 \end{aligned}$ | 1.2 | $\begin{aligned} & \mathrm{MHz} \\ & \mathrm{kHz} \\ & \mathrm{~V} / \mu \mathrm{s} \\ & \mu \mathrm{~s} \\ & \% \end{aligned}$ |
| INPUT IMPEDANCE Differential Common Mode | - |  | $\begin{aligned} & 3 \times 10^{12} \mid 5.5 \\ & 3 \times 10^{12}\| \| 5.5 \end{aligned}$ |  |  | $\begin{aligned} & 3 \times 10^{12} \\| 5.5 \\ & 3 \times 10^{12} \\| 5.5 \\ & \hline \end{aligned}$ |  | $\begin{aligned} & \Omega \\| \mathrm{pF} \\ & \Omega \\| \mathrm{pF} \\ & \hline \end{aligned}$ |
| INPUT VOLTAGE RANGE <br> Differential ${ }^{3}$ Common-Mode Voltage ${ }^{4}$ <br> Common Mode <br> Rejection Ratio | $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ <br> $\mathrm{V}_{\mathrm{CM}}= \pm 10 \mathrm{~V}$ <br> $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ <br> $\mathrm{V}_{\mathrm{CM}}= \pm 11 \mathrm{~V}$ <br> $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ | $-11$ <br> 78 <br> 76/76/76 <br> 72 <br> 70/70/70 | $\begin{aligned} & \pm 20 \\ & +14.5,-11.5 \\ & 88 \\ & 84 \\ & 84 \\ & 80 \\ & \hline \end{aligned}$ | +13 | $\begin{array}{\|l\|} \hline-11 \\ 84 \\ 82 \\ 78 \\ 74 \\ \hline \end{array}$ | $\begin{aligned} & \pm 20 \\ & +14.5,-11.5 \\ & 94 \\ & 90 \\ & 90 \\ & 84 \\ & \hline \end{aligned}$ | +13 | $\begin{array}{\|l} \mathrm{V} \\ \mathrm{~V} \\ \mathrm{~V} \\ \mathrm{~dB} \\ \mathrm{~dB} \\ \mathrm{~dB} \\ \mathrm{~dB} \\ \hline \end{array}$ |
| INPUT VOLTAGE NOISE | $\begin{aligned} & 0.1 \mathrm{~Hz} \text { to } 10 \mathrm{~Hz} \\ & \mathrm{f}=10 \mathrm{~Hz} \\ & \mathrm{f}=100 \mathrm{~Hz} \\ & \mathrm{f}=1 \mathrm{kHz} \\ & \mathrm{f}=10 \mathrm{kHz} \end{aligned}$ |  | $\begin{aligned} & 2 \\ & 45 \\ & 22 \\ & 18 \\ & 16 \\ & \hline \end{aligned}$ |  |  | $\begin{aligned} & 2 \\ & 45 \\ & 22 \\ & 18 \\ & 16 \end{aligned}$ |  | $\begin{aligned} & \mu \mathrm{V} \text { p-p } \\ & \mathrm{nV} / \sqrt{\mathrm{Hz}} \\ & \mathrm{nV} / \sqrt{\mathrm{Hz}} \\ & \mathrm{nV} / \sqrt{\mathrm{Hz}} \\ & \mathrm{nV} / \sqrt{\mathrm{Hz}} \end{aligned}$ |
| INPUT CURRENT NOISE | $\mathrm{f}=1 \mathrm{kHz}$ |  | 0.01 |  |  | 0.01 |  | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
| OPEN-LOOP GAIN | $\begin{array}{\|l} \mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V} ; \mathrm{R}_{\mathrm{L}} \geq 2 \mathrm{k} \Omega \\ \mathrm{~T}_{\text {MIN }} \text { to } \mathrm{T}_{\text {MAX }} \end{array}$ | $\begin{array}{\|l\|} \hline 150 \\ 100 / 100 / 100 \\ \hline \end{array}$ | 400 |  | $\begin{array}{\|l\|} 200 \\ 100 \\ \hline \end{array}$ | 400 |  | $\begin{aligned} & \mathrm{V} / \mathrm{mV} \\ & \mathrm{~V} / \mathrm{mV} \\ & \hline \end{aligned}$ |
|  | $\begin{aligned} & \mathrm{R}_{\mathrm{L}} \geq 2 \mathrm{k} \Omega \\ & \mathrm{~T}_{\text {MIN }} \text { to } \mathrm{T}_{\text {MAX }} \\ & \text { Short Circuit } \\ & \hline \end{aligned}$ | $\begin{aligned} & +13,-12.5 \\ & \pm 12 / \pm 12 / \pm 12 \end{aligned}$ | $\begin{aligned} & +13.9,-13.3 \\ & +13.8,-13.1 \\ & 25 \end{aligned}$ |  | $\begin{aligned} & +13,-12.5 \\ & \pm 12 \end{aligned}$ | $\begin{aligned} & +13.9,-13.3 \\ & +13.8,-13.1 \\ & 25 \end{aligned}$ |  | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~mA} \end{aligned}$ |
| POWER SUPPLY <br> Rated Performance Operating Range Quiescent Current |  | $\pm 4.5$ | $\begin{aligned} & \pm 15 \\ & 10.0 \\ & \hline \end{aligned}$ | $\begin{gathered} \pm 18 \\ 13.5 \\ \hline \end{gathered}$ | $\pm 4.5$ | $\begin{aligned} & \pm 15 \\ & 10.0 \\ & \hline \end{aligned}$ | $\begin{gathered} \pm 18 \\ 12.0 \\ \hline \end{gathered}$ | V <br> V <br> mA |
| TRANSISTOR COUNT | \# of Transistors |  | 120 |  | : | 120 |  |  |

## NOTES

${ }^{1}$ Input Offset Voltage specifications are guaranteed after 5 minutes of operation at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.
${ }^{2}$ Bias Current specifications are guaranteed maximum at either input after 5 minutes of operation at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. For higher temperatures, the current doubles every $10^{\circ} \mathrm{C}$.
${ }^{3}$ Defined as voltage between inputs, such that neither exceeds $\pm 10 \mathrm{~V}$ from ground.
${ }^{4}$ Typically exceeding -14.1 V negative common-mode voltage on either input results in an output phase reversal.
Specifications subject to change without notice.

| ABSOLUTE MAXIMUM RATINGS ${ }^{1}$ |  |
| :---: | :---: |
| Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 18$ V <br> Internal Power Dissipation ${ }^{2}$ |  |
|  |  |
| Input Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm \mathrm{V}_{\text {S }}$ |  |
| Differential Input Voltage |  |
| Output Short Circuit Duration (Single Amplifier) . . . Indefinite |  |
| Storage Temperature Range (N, R) . . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  |
| Storage Temperature Range (Q) . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |  |
| Operating Temperature Range |  |
| AD71xJ/K . . . . . . . . . . . . . . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ |  |
| AD71xA/B . . . . . . . . . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |
| AD71xS/T . . . . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  |
| Lead Temperature Range (Soldering 60 sec ) . . . . . . $+300^{\circ} \mathrm{C}$ |  |
| NOTES |  |
| ${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. |  |
| ${ }^{2}$ Specification is for device in free air: |  |
| 8 -Pin Plastic Package | $\theta_{\text {JA }}=165^{\circ} \mathrm{C} / \mathrm{W}_{\text {att }}$ |
| 8 -Pin Cerdip Package | $\theta_{\text {JA }}=110^{\circ} \mathrm{C} /$ Watt |
| 8 -Pin Metal Can Package | $\theta_{\text {JA }}=150^{\circ} \mathrm{C} / \mathrm{W}_{\text {att }}$ |
| 8 -Pin Small Outline Package | $\theta_{\text {JA }}=155^{\circ} \mathrm{C} /$ Watt |
| 14-Pin Plastic Package | $\theta_{\text {IA }}=150^{\circ} \mathrm{C} / \mathrm{W}_{\text {att }}$ |
| 14-Pin Cerdip Package | $\theta_{\text {JA }}=110^{\circ} \mathrm{C} /$ Watt |
| 16-Pin SOIC Package | $\theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} / \mathrm{W}_{\text {att }}$ |

ORDERING GUIDE

| Model | Temperature Range | Package Description | Package Option ${ }^{\star}$ |
| :---: | :---: | :---: | :---: |
| AD711AH | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Metal Can | H-08A |
| AD711AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Ceramic DIP | Q-8 |
| AD711BH | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Metal Can | H-08A |
| AD711BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Ceramic DIP | Q-8 |
| AD711CH | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Metal Can | H-08A |
| AD711CQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Ceramic DIP | Q-8 |
| AD711JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | N-8 |
| AD711JR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | R-8 |
| AD711JR-REEL | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | R-8 |
| AD711JR-REEL7 | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | R-8 |
| AD711KN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | N-8 |
| AD711KR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | R-8 |
| AD711KR-REEL | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | R-8 |
| AD711KR-REEL7 | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | R-8 |
| AD711SCHIPS | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Bare Die |  |
| AD711SQ/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Ceramic DIP | Q-8 |
| AD711TQ/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Ceramic DIP | Q-8 |
| AD712ACHIPS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Bare Die |  |
| AD712AH | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Metal Can | H-08A |
| AD712AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Ceramic DIP | Q-8 |
| AD712BH | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Metal Can | H-08A |
| AD712BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Ceramic DIP | Q-8 |
| AD712CH | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Metal Can | H-08A |
| AD712CQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Ceramic DIP | Q-8 |
| AD712JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | N-8 |
| AD712JR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | R-8 |
| AD712JR-REEL | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | R-8 |
| AD712JR-REEL7 | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | R-8 |
| AD712KN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | N-8 |
| AD712KR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | R-8 |
| AD712KR-REEL | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | R-8 |
| AD712KR-REEL7 | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | R-8 |
| AD712SCHIPS | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Bare Die |  |
| AD712SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Ceramic DIP | Q-8 |
| AD712SQ/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Ceramic DIP | Q-8 |
| AD712TQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Ceramic DIP | Q-8 |
| AD712TQ/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Ceramic DIP | Q-8 |
| AD713AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 14-Pin Ceramic DIP | Q-14 |
| AD713BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 14-Pin Ceramic DIP | Q-14 |
| AD713JCHIPS | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Bare Die |  |
| AD713JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 14-Pin Plastic DIP | N-14 |
| AD713JR-16 | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 16-Pin Plastic SOIC | R-16 |
| AD713JR-16-REEL | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 16-Pin Plastic SOIC | R-16 |
| AD713JR-16-REEL7 | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 16-Pin Plastic SOIC | R-16 |
| AD713KN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 14-Pin Plastic DIP | N-14 |
| AD713SCHIPS | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Bare Die |  |
| AD713SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 14-Pin Ceramic DIP | Q-14 |
| AD713SQ/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 14-Pin Ceramic DIP | Q-14 |
| AD713TQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 14-Pin Ceramic DIP | Q-14 |
| AD713TQ/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 14-Pin Ceramic DIP | Q-14 |
| 5962-9063301MCA | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 14-Pin Ceramic DIP | Q-14 |
| 5962-9063302MCA | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 14-Pin Ceramic DIP | Q-14 |

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## FEATURES

## ULTRALOW NOISE PERFORMANCE

## $2.9 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ at 10 kHz

$0.38 \mu \mathrm{~V}$ p-p, 0.1 to 10 Hz
$6.9 \mathrm{fA} / \sqrt{\mathrm{Hz}}$ Current Noise at 1 kHz
EXCELLENT DC PERFORMANCE
0.5 mV max Offset Voltage

250 pA max Input Bias Current
$1000 \mathrm{~V} / \mathrm{mV}$ min Open-Loop Gain
ac Performance
2.8 V/ $\mu \mathrm{s}$ Slew Rate
4.5 MHz Unity-Gain Bandwidth

THD = 0.0003\% @ 1 kHz
Available in Tape and Reel in Accordance with
EIA-481A Standard

## APPLICATIONS

Sonar Preamplifiers
High Dynamic Range Filters ( $>140 \mathrm{~dB}$ )
Photodiode and IR Detector Amplifiers
Accelerometers

## PRODUCT DESCRIPTION

The AD743 is an ultralow noise precision, FET input, monolithic operational amplifier. It offers a combination of the ultralow voltage noise generally associated with bipolar input op amps and the very low input current of a FET-input device. Furthermore, the AD743 does not exhibit an output phase reversal when the negative common-mode voltage limit is exceeded.
The AD743's guaranteed, maximum input voltage noise of $4.0 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ at 10 kHz is unsurpassed for a FET-input monolithic op amp, as is the maximum $1.0 \mu \mathrm{~V}$ p-p, 0.1 to 10 Hz noise. The AD743 also has excellent dc performance with 250 pA maximum input bias current and 0.5 mV maximum offset voltage.
The AD743 is specifically designed for use as a preamp in capacitive sensors, such as ceramic hydrophones. It is available in five performance grades. The AD743J and AD743K are rated over the commercial temperature range of $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$. The AD743A and AD743B are rated over the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. The AD743S is rated over the military temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ and is available processed to MIL-STD-883B, Rev. C.
The AD743 is available in 8-pin plastic mini-DIP, 8-pin cerdip, 16-pin SOIC, or in chip form.

## CONNECTION DIAGRAMS



## PRODUCT HIGHLIGHTS

1. The low offset voltage and low input offset voltage drift of the AD743 coupled with its ultralow noise performance mean that the AD743 can be used for upgrading many applications now using bipolar amplifiers.
2. The combination of low voltage and low current noise make the AD743 ideal for charge sensitive applications such as accelerometers and hydrophones.
3. The low input offset voltage and low noise level of the AD743 provide $>140 \mathrm{~dB}$ dynamic range.
4. The typical 10 kHz noise level of $2.9 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ permits a three op amp instrumentation amplifier, using three AD743s, to be built which exhibits less than $4.2 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ noise at 10 kHz and which has low input bias currents.


Input Noise Voltage vs. Source Resistance

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## NOTES

${ }^{1}$ Input offset voltage specifications are guaranteed after 5 minutes of operation at $T_{A}=+25^{\circ} \mathrm{C}$.
${ }^{2}$ Test conditions: $+\mathrm{V}_{\mathrm{S}}=15 \mathrm{~V},-\mathrm{V}_{\mathrm{S}}=12 \mathrm{~V}$ to 18 V and $+\mathrm{V}_{\mathrm{S}}=12 \mathrm{~V}$ to $+18 \mathrm{y},-\mathrm{V}_{\mathrm{S}}=15 \mathrm{~V}$.
${ }^{3}$ Bias current specifications are guaranteed maximum at either input after 5 minutes of operation at $T_{A}=+25^{\circ} \mathrm{C}$. For higher temperature, the current doubles every $10^{\circ} \mathrm{C}$.
${ }^{4}$ Gain $=-1, R_{L}=2 \mathrm{k} \Omega, C_{L}=10 \mathrm{pF}$.
${ }^{5}$ Defined as voltage between inputs, such that neither exceeds $\pm 10 \mathrm{~V}$ from common.
${ }^{6}$ The AD743 does not exhibit an output phase reversal when the negative common-mode limit is exceeded.
All $\min$ and max specifications are guaranteed.
Specifications subject to change without notice.

| ABSOLUTE MAXIMUM RATINGS ${ }^{1}$ |  |
| :---: | :---: |
| Supply Voltage | 18 V |
| Internal Power Dissipation ${ }^{2}$ |  |
| Input Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm \mathrm{V}_{\text {S }}$ |  |
| Output Short Circuit Duration . . . . . . . . . . . . . . Indefinite |  |
| Differential Input Voltage . . . . . . . . . . . . $+\mathrm{V}_{\text {S }}$ and $-\mathrm{V}_{\text {S }}$ |  |
| Storage Temperature Range (Q) . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |  |
| Storage Temperature Range (N, R) . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  |
| Operating Temperature Range |  |
| AD743J/K | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ |
| AD743A/B | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| AD743S | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
|  | $300^{\circ} \mathrm{C}$ |

## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2} 8$-pin plastic package: $\theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} / \mathrm{Watt}, \theta_{\mathrm{JC}}=50^{\circ} \mathrm{C} / \mathrm{Watt}$
8-pin cerdip package: $\theta_{\mathrm{JA}}=110^{\circ} \mathrm{C} / \mathrm{Watt}, \theta_{\mathrm{JC}}=30^{\circ} \mathrm{C} / \mathrm{Watt}$ 16-pin plastic SOIC package: $\theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} / \mathrm{Watt}, \theta_{\mathrm{JC}}=30^{\circ} \mathrm{C} / \mathrm{W}$ att

## ESD SUSCEPTIBILITY

An ESD classification per method 3015.6 of MIL STD 883C has been performed on the AD743. The AD743 is a class 1 device, passing at 1000 V and failing at 1500 V on nuill pins 1 and 5, when tested, using an IMCS 5000 automated ESD tester. Pins other than null pins fail at greater than 2500 V .

## ORDERING GUIDE

| Model | Temperature Range | Package <br> Option |
| :--- | :--- | :--- |
| AD743JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| AD743KN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| AD743AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| AD743JR-16 | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{R}-16$ |
| AD743KR-16 | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{R}-16$ |
| AD743AR-16 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16$ |
| AD743AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |
| AD743BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |
| AD743SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |
| AD743SQ/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |
| AD743JCHIPS | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Die |
| AD743JR-16-REEL | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Tape \& Reel |
| AD743KR-16-REEL | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Tape \& Reel |
| AD743AR-16-REEL | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Tape \& Reel |

* $\mathrm{N}=$ Plastic DIP; $\mathrm{R}=$ Small Outline IC; $\mathrm{Q}=$ Cerdip. For outline information see Package Information section.


## METALIZATION PHOTOGRAPH

Contact factory for latest dimensions.
Dimensions shown in inches and (mm).


## FEATURES

AC PERFORMANCE
500ns Settling to $\mathbf{0 . 0 1 \%}$ for 10 V Step
$1.5 \mu \mathrm{~s}$ Settling to $0.0025 \%$ for 10 V Step
75V/ $\mu$ s Slew Rate
0.0003\% Total Harmonic Distortion (THD)

13MHz Gain Bandwidth - Internal Compensation
$>\mathbf{2 0 0 M H z}$ Gain Bandwidth ( $\mathbf{G}=1000$ )
External Decompensation
$>1000$ pF Capacitive Load Drive Capability with 10V/ $\mu$ s Slew Rate - External Compensation
DC PERFORMANCE
0.25 mV max Offset Voltage (AD744C)
$3 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ max Drift (AD744C)
$250 \mathrm{~V} / \mathrm{mV}$ min Open-Loop Gain (AD744B)
$4 \mu V$ p-p max Noise, 0.1 Hz to 10 Hz (AD744C)
Available in Plastic Mini-DIP, Plastic SOIC, Hermetic
Cerdip, Hermetic Metal Can Packages and Chip Form
MIL-STD-883B Processing Available
Surface Mount (SOIC) Package Available in Tape and Reel in Accordance with EIA-481A Standard

## APPLICATIONS

Output Buffers for 12-Bit, 14-Bit and 16-Bit DACs, ADC Buffers, Cable Drivers, Wideband Preamplifiers and Active Filters

## PRODUCT DESCRIPTION

The AD744 is a fast-settling, precision, FET input, monolithic operational amplifier. It offers the excellent dc characteristics of the AD711 BiFET family with enhanced settling, slew rate, and bandwidth. The AD744 also offers the option of using custom compensation to achieve exceptional capacitive load drive capability.
The single-pole response of the AD744 provides fast settling: 500 ns to $0.01 \%$. This feature, combined with its high dc precision, makes it suitable for use as a buffer amplifier for 12 -bit, 14 -bit or 16-bit DACs and ADCs. Furthermore, the AD744's low total harmonic distortion (THD) level of $\mathbf{0 . 0 0 0 3 \%}$ and gain bandwidth product of 13 MHz make it an ideal amplifier for demanding audio applications. It is also an excellent choice for use in active filters in 12-bit, 14-bit and 16-bit data acquisition systems.
The AD744 is internally compensated for stable operation as a unity gain inverter or as a noninverting amplifier with a gain of two or greater. External compensation may be applied to the AD744 for stable operation as a unity gain follower. External compensation also allows the AD744 to drive 1000 pF capacitive loads, slewing at $10 \mathrm{~V} / \mu \mathrm{s}$ with full stability. Alternatively, external decompensation may be used to increase the gain bandwidth of

## CONNECTION DIAGRAMS


the AD744 to over 200 MHz at high gains. This makes the AD744 ideal for use as ac preamps in digital signal processing (DSP) front ends.

The AD744 is available in seven performance grades. The AD744J and AD744K are rated over the commercial temperature range of 0 to $+70^{\circ} \mathrm{C}$. The AD744A, AD744B and AD744C are rated over the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. The AD744S and AD744T are rated over the military temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ and are available processed to MIL-STD-883B, Rev. C.

Extended reliability PLUS screening is available, specified over the commercial and industrial temperature ranges. PLUS screening includes a 168 -hour burn-in, as well as other environmental and physical tests.
The AD744 is available in an 8-pin plastic mini-DIP, 8-pin small outline, 8 -pin cerdip or TO-99 metal can.

## PRODUCT HIGHLIGHTS

1. The AD744 is a high-speed BiFET op amp that offers excellent performance at competitive prices. It outperforms the OPA602/ OPA606, LF356 and LF400.
2. The AD744 offers exceptional dynamic response. It settles to $0.01 \%$ in 500 ns and has a $100 \%$ tested minimum slew rate of $50 \mathrm{~V} / \mu \mathrm{s}$ (AD744B).
3. The combination of Analog Devices' advanced processing technology, laser wafer drift trimming and well-matched ionimplanted JFETs provide outstanding dc precision. Input offset voltage, input bias current, and input offset current are specified in the warmed-up condition; all are $100 \%$ tested.
4. The AD744 has a guaranteed and tested maximum voltage noise of $4 \mu \mathrm{~V}$ p-p, 0.1 Hz to 10 Hz (AD744C).

[^135]

## NOTES

${ }^{1}$ Input Offset Voltage specifications are guaranteed after 5 minutes of operation at $T_{A}=+25^{\circ} \mathrm{C}$.
${ }^{2}$ PSRR test conditions: $+\mathrm{V}_{\mathrm{s}}=15 \mathrm{~V},-\mathrm{V}_{\mathrm{s}}=-12 \mathrm{~V}$ to -18 V and $+\mathrm{V}_{\mathrm{s}}=12 \mathrm{~V}$ to $18 \mathrm{~V},-\mathrm{V}_{\mathrm{s}}=-15 \mathrm{~V}$.
${ }^{3}$ Bias Current $S$ pecifications are guaranteed maximum at either input after 5 minutes of operation at $T_{A}=+25^{\circ} \mathrm{C}$. For higher temperature, the current doubles every $10^{\circ} \mathrm{C}$.
${ }^{4}$ Gain $=-1, R_{L}=2 k, C_{L}=10 \mathrm{pF}$, refer to Figure 25.
${ }^{5}$ Defined as voltage between inputs, such that neither exceeds $\pm 10 \mathrm{~V}$ from ground.
${ }^{6}$ Typically exceeding -14.1V negative common-mode voltage on either input results in an output phase reversal.
${ }^{\prime}$ Open-Loop Gain is specified with $V_{\text {os }}$ both nulled and unnulled:
${ }^{8}$ Capacitive load drive specified for $\mathrm{C}_{\text {COMP }}=20 \mathrm{pF}$ with the device connected as shown in Figure 32. Under these conditions, slew rate $=14 \mathrm{~V} / \mu \mathrm{s}$ and $0.01 \%$ settling time $=1.5 \mu \mathrm{~S}$ typical.
Refer to Table II for optimum compensation while driving a capacitive load.
${ }^{9}$ For outline information see Package Information section.
Specifications subject to change without notice.
Specifications in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.

| ABSOLUTE MAXIMUM RATINGS ${ }^{1}$ |  |
| :---: | :---: |
| Supply Voltage | 18 V |
| Internal Power Dissipation ${ }^{2}$ | 500 mW |
| Input Voltage ${ }^{3}$ | 18V |
| Output Short Circuit Duration | Indefinite |
| Differential Input Voltage | $+V_{S}$ and $-V_{\text {S }}$ |
| Storage Temperature Range (Q, H) | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Storage Temperature Range (N, R) | $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Operating Temperature Range |  |
| AD744J/K | 0 to $+70^{\circ} \mathrm{C}$ |
| AD744A/B/C | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| AD744S/T | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Lead Temperature Range (Soldering 60 sec ) | $300^{\circ} \mathrm{C}$ |

## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions above those indited in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ Thermal Characteristics
8-Pin Plastic Package: $\theta_{\mathrm{JC}}=33^{\circ} \mathrm{C} / \mathrm{W}, \theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} / \mathrm{W}$
8-Pin Cerdip Package: $\theta_{\mathrm{JC}}=22^{\circ} \mathrm{C} / \mathrm{W}, \theta_{\mathrm{JA}}=110^{\circ} \mathrm{C} / \mathrm{W}$
8 -Pin Metal Can Package: $\theta_{\mathrm{JC}}=65^{\circ} \mathrm{C} / \mathrm{W}, \theta_{\mathrm{JA}}=150^{\circ} \mathrm{C} / \mathrm{W}$
8 -Pin SOIC Package: $\theta_{\mathrm{JC}}=42^{\circ} \mathrm{C} / \mathrm{W}, \theta_{\mathrm{JA}}=160^{\circ} \mathrm{C} / \mathrm{W}$
${ }^{3}$ For supply voltages less than $\pm 18 \mathrm{~V}$, the absolute maximum input voltage is equal to the supply voltage.

## METALIZATION PHOTOGRAPH

Contact factory for latest dimensions.
Dimensions shown in inches and (mm).


## FEATURES

ULTRALOW NOISE PERFORMANCE
$2.9 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ at 10 kHz
$0.38 \mu \mathrm{~V}$ p-p, 0.1 Hz to 10 Hz
$6.9 \mathrm{fA} / \sqrt{\mathrm{Hz}}$ Current Noise at $1 \mathbf{k H z}$

## EXCELLENT AC PERFORMANCE

12.5 V/ $\mu \mathrm{s}$ Slew Rate
20 MHz Gain Bandwidth Product
THD = 0.0002\% @ 1 kHz
Internally Compensated for Gains of +5 (or -4 ) or
Greater

## EXCELLENT DC PERFORMANCE

0.5 mV max Offset Voltage
250 pA max Input Bias Current
2000 V/mV min Open Loop Gain
Available in Tape and Reel in Accordance with
EIA-481A Standard

## APPLICATIONS

## Sonar

Photodiode and IR Detector Amplifiers
Accelerometers
Low Noise Preamplifiers
High Performance Audio

## PRODUCT DESCRIPTION

The AD745 is an ultralow noise, high speed, FET input operational amplifier. It offers both the ultralow voltage noise and high speed generally associated with bipolar input op amps and the very low input currents of FET input devices. Its 20 MHz bandwidth and $12.5 \mathrm{~V} / \mu \mathrm{s}$ slew rate makes the AD745 an ideal amplifier for high speed applications demanding low noise and high dc precision. Furthermore, the AD745 does not exhibit an output phase reversal.


CONNECTION DIAGRAMS


The AD745's guaranteed, tested maximum input voltage noise of $4 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ at 10 kHz is unsurpassed for a FET-input monolithic op amp, as is its maximum $1.0 \mu \mathrm{~V}$ p-p noise in a 0.1 to 10 Hz bandwidth. The AD745 also has excellent dc performance with 250 pA maximum input bias current and 0.5 mV maximum offset voltage.
The internal compensation of the AD745 is optimized for higher gains, providing a much higher bandwidth and a faster slew rate. This makes the AD745 especially useful as a preamplifier where low level signals require an amplifier that provides both high amplification and wide bandwidth at these higher gains. The AD745 is available in five performance grades. The AD745J and AD745K are rated over the commercial temperature range of $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$. The AD745A and AD745B are rated over the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. The AD745S is rated over the military temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ and is available processed to MIL-STD-883B, Rev. C.
The AD745 is available in 8-pin plastic mini-DIP, 8-pin cerdip, 16 -pin SOIC, or in chip form.


| Model | Conditions | AD745J/A |  |  | AD745K/B |  |  | AD745S |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max | Min | Typ | Max | Min | Ty | Max |  |
| INPUT OFFSET VOLTAGE ${ }^{1}$ <br> Initial Offset <br> Initial Offset <br> vs. Temp. <br> vs. Supply (PSRR) <br> vs. Supply (PSRR) | $\begin{aligned} & \mathrm{T}_{\min } \text { to } \mathrm{T}_{\max } \\ & \mathrm{T}_{\min } \text { to } \mathrm{T}_{\max } \\ & 12 \mathrm{~V} \text { to } 18 \mathrm{~V}^{2} \\ & \mathrm{~T}_{\text {min }} \text { to } \mathrm{T}_{\text {max }} \end{aligned}$ | $\begin{aligned} & 90 \\ & 88 \end{aligned}$ | $\begin{aligned} & 0.25 \\ & 2 \\ & 96 \end{aligned}$ | $\begin{aligned} & 1.0 / 0.8 \\ & 1.5 \end{aligned}$ | $\begin{aligned} & 100 \\ & 98 \end{aligned}$ | $\begin{aligned} & 0.1 \\ & 2 \\ & 106 \\ & 105 \end{aligned}$ | $\begin{aligned} & 0.5 / 0.25 \\ & 1.0 / 0.50 \end{aligned}$ | $\begin{aligned} & 90 \\ & 88 \end{aligned}$ | $\begin{aligned} & 0.25 \\ & 2 \\ & 96 \end{aligned}$ | $\begin{aligned} & 1.0 \\ & 2.0 \end{aligned}$ | $\begin{aligned} & \mathrm{mV} \\ & \mathrm{mV} \\ & \mu \mathrm{~V} /{ }^{\circ} \mathrm{C} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \end{aligned}$ |
| INPUT BIAS CURRENT ${ }^{3}$ <br> Either Input <br> Either Input (a) $\mathrm{T}_{\max }$ <br> Either Input <br> Either Input, $\mathrm{V}_{\mathrm{S}}= \pm 5 \mathrm{~V}$ | $\begin{aligned} \mathrm{V}_{\mathrm{CM}} & =0 \mathrm{~V} \\ \mathrm{~V}_{\mathrm{CM}} & =0 \mathrm{~V} \\ \mathrm{~V}_{\mathrm{CM}} & =+10 \mathrm{~V} \\ \mathrm{~V}_{\mathrm{CM}} & =0 \mathrm{~V} \end{aligned}$ |  | $\begin{aligned} & 150 \\ & 250 \\ & 30 \end{aligned}$ | $\begin{aligned} & 400 \\ & \\ & 8.8 / 25.6 \\ & 600 \\ & 200 \end{aligned}$ |  | $\begin{aligned} & 150 \\ & 250 \\ & 30 \end{aligned}$ | $\begin{aligned} & 250 \\ & \\ & 5.5 / 16 \\ & 400 \\ & 125 \end{aligned}$ |  | $\begin{aligned} & 150 \\ & 300 \\ & 30 \end{aligned}$ | $\begin{aligned} & 400 \\ & 413 \\ & 600 \\ & 200 \end{aligned}$ | $\begin{aligned} & \mathrm{pA} \\ & \mathrm{nA} \\ & \mathrm{pA} \\ & \mathrm{pA} \end{aligned}$ |
| INPUT OFFSET CURRENT <br> Offset Current <br> (a $\mathrm{T}_{\text {max }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V} \end{aligned}$ |  | 40 | $\begin{aligned} & 150 \\ & 2.2 / 6.4 \end{aligned}$ |  | 30 | $\begin{aligned} & 75 \\ & 1.1 / 3.2 \end{aligned}$ |  | 40 | $\begin{aligned} & 150 \\ & 102 \end{aligned}$ | pA <br> nA |
| FREQUENCY RESPONSE <br> Gain BW, Small Signal <br> Full Power Response <br> Slew Rate <br> Settling Time to $0.01 \%$ Total Harmonic Distortion ${ }^{4}$ | $\begin{aligned} & \mathrm{G}=-4 \\ & \mathrm{~V}_{\mathrm{O}}=20 \mathrm{~V} \text { p-p } \\ & \mathrm{G}=-4 \\ & \mathrm{f}=1 \mathrm{kHz} \\ & \mathrm{G}=-4 \end{aligned}$ |  | $\begin{aligned} & 20 \\ & 120 \\ & 12.5 \\ & 5 \\ & \\ & 0.0002 \end{aligned}$ |  |  | 20 <br> 120 <br> 12.5 <br> 5 <br> 0.0002 |  |  | $\begin{aligned} & 20 \\ & 120 \\ & 12.5 \\ & 5 \\ & 0.0002 \end{aligned}$ |  | $\begin{aligned} & \mathrm{MHz} \\ & \mathrm{kHz} \\ & \mathrm{~V} / \mu \mathrm{s} \\ & \mu \mathrm{~s} \\ & \% \end{aligned}$ |
| INPUT IMPEDANCE <br> Differential Common Mode |  |  | $\begin{aligned} & 1 \times 10 \\ & 3 \times 10 \end{aligned}$ |  |  | $\begin{aligned} & 1 \times 10 \\ & 3 \times 10 \end{aligned}$ |  |  | $\begin{aligned} & 1 \times \\ & 3 \times \end{aligned}$ |  | $\begin{aligned} & \Omega \\| \mathrm{pF} \\ & \Omega \\| \mathrm{pF} \end{aligned}$ |
| INPUT VOLTAGE RANGE <br> Differential ${ }^{5}$ Common-Mode Voltage Over Max Operating Range ${ }^{6}$ Common-Mode Rejection Ratio | $\begin{aligned} & \mathrm{V}_{\mathrm{CM}}= \pm 10 \mathrm{~V} \\ & \mathrm{~T}_{\min } \text { to } \mathrm{T}_{\max } \end{aligned}$ | $-10$ <br> 80 <br> 78 | $\begin{aligned} & \pm 20 \\ & +13.3, \\ & \vdots \\ & 95 \end{aligned}$ | $+12$ | $\begin{aligned} & -10 \\ & 90 \\ & 88 \end{aligned}$ | $\begin{aligned} & \pm 20 \\ & +13.3, \\ & 102 \end{aligned}$ | $+12$ | $\begin{aligned} & -10 \\ & 80 \\ & 78 \end{aligned}$ | $\begin{aligned} & \pm 20 \\ & +13.3 \end{aligned}$ | +12 | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \end{aligned}$ |
| INPUT VOLTAGE NOISE | $\begin{aligned} & 0.1 \text { to } 10 \mathrm{~Hz} \\ & \mathrm{f}=10 \mathrm{~Hz} \\ & \mathrm{f}=100 \mathrm{~Hz} \\ & \mathrm{f}=1 \mathrm{kHz} \\ & \mathrm{f}=10 \mathrm{kHz} \end{aligned}$ |  | $\begin{aligned} & \hline 0.38 \\ & 5.5 \\ & 3.6 \\ & 3.2 \\ & 2.9 \end{aligned}$ | $\begin{aligned} & 5.0 \\ & 4.0 \end{aligned}$ |  | $\begin{aligned} & \hline 0.38 \\ & 5.5 \\ & 3.6 \\ & 3.2 \\ & 2.9 \end{aligned}$ | $\begin{aligned} & 1.0 \\ & 10.0 \\ & 6.0 \\ & 5.0 \\ & 4.0 \end{aligned}$ |  | $\begin{aligned} & 0.38 \\ & 5.5 \\ & 3.6 \\ & 3.2 \\ & 2.9 \end{aligned}$ | $\begin{aligned} & 5.0 \\ & 4.0 \end{aligned}$ | $\mu \mathrm{V}$ p-p <br> $\mathrm{nV} / \sqrt{ } \mathrm{Hz}$ <br> $\mathrm{nV} / \sqrt{ } \mathrm{Hz}$ <br> $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ <br> $\mathrm{nV} / \sqrt{ } \mathrm{Hz}$ |
| INPUT CURRENT NOISE | $\mathrm{f}=1 \mathrm{kHz}$ |  | 6.9 |  |  | 6.9 |  |  | 6.9 |  | $\mathrm{fA} / \sqrt{ } \mathrm{Hz}$ |
| OPEN LOOP GAIN | $\begin{aligned} & \mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{LOAD}} \geq 2 \mathrm{k} \Omega \\ & \mathrm{~T}_{\min } \text { to } \mathrm{T}_{\max } \\ & \mathrm{R}_{\text {LOAD }}=600 \Omega \\ & \hline \end{aligned}$ | $\begin{aligned} & 1000 \\ & 800 \end{aligned}$ | $\begin{aligned} & 4000 \\ & 1200 \end{aligned}$ |  | $\begin{aligned} & 2000 \\ & 1800 \end{aligned}$ | $\begin{aligned} & 4000 \\ & 1200 \end{aligned}$ |  | $\begin{aligned} & 1000 \\ & 800 \end{aligned}$ | $\begin{aligned} & 4000 \\ & 1200 \end{aligned}$ |  | $\mathrm{V} / \mathrm{mV}$ <br> $\mathrm{V} / \mathrm{mV}$ <br> V/mV |
| OUTPUT CHARACTERISTICS <br> Voltage <br> Current | $R_{\text {LOAD }} \geq 600 \Omega$ <br> $\mathrm{R}_{\text {LOAD }} \geq 600 \Omega$ <br> $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ <br> $\mathrm{R}_{\text {LOAD }} \geq 2 \mathrm{k} \Omega$ <br> Short Circuit | $\left\lvert\, \begin{aligned} & +13 \\ & +12, \\ & \pm 12 \\ & 20 \end{aligned}\right.$ | $\begin{aligned} & +13.6, \\ & +13.8, \\ & 40 \end{aligned}$ |  | $\begin{aligned} & +13, \\ & +12, \\ & \pm 12 \\ & 20 \end{aligned}$ | $\begin{aligned} & +13.6, \\ & +13.8, \\ & 40 \end{aligned}$ |  | $\begin{aligned} & +13 \\ & +12, \\ & \pm 12 \\ & 20 \end{aligned}$ | $\begin{aligned} & +13.6 \\ & +13.8 \\ & 40 \end{aligned}$ |  | V V V V m |
| POWER SUPPLY <br> Rated Performance Operating Range Quiescent Current |  | $\pm 4.8$ | $\begin{aligned} & \pm 15 \\ & 8 \end{aligned}$ | $\begin{aligned} & \pm 18 \\ & 10.0 \end{aligned}$ | $\pm 4.8$ | $\begin{aligned} & \pm 15 \\ & 8 \end{aligned}$ | $\begin{aligned} & \pm 18 \\ & 10.0 \end{aligned}$ | $\pm 4.8$ | $\begin{aligned} & \pm 15 \\ & 8 \end{aligned}$ | $\begin{aligned} & \pm 18 \\ & 10.0 \end{aligned}$ | V <br> V <br> mA |
| TRANSISTOR COUNT | \# of Transistors |  | 50 |  |  | 50 |  |  | 50 |  |  |

## NOTES

${ }^{1}$ Input offset voltage specifications are guaranteed after 5 minutes of operation at $T_{A}=+25^{\circ} \mathrm{C}$.
${ }^{2}$ Test conditions: $+\mathrm{V}_{\mathrm{S}}=15 \mathrm{~V},-\mathrm{V}_{\mathrm{S}}=12 \mathrm{~V}$ to 18 V and $+\mathrm{V}_{\mathrm{S}}=12 \mathrm{~V}$ to $+18 \mathrm{~V},-\mathrm{V}_{\mathrm{S}}=15 \mathrm{~V}$.
${ }^{3}$ Bias current specifications are guaranteed maximum at either input after 5 minutes of operation at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. For higher temperature, the current doubles every $10^{\circ} \mathrm{C}$.
${ }^{4}$ Gain $=-4, \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}$.
${ }^{5}$ Defined as voltage between inputs, such that neither exceeds $\pm 10 \mathrm{~V}$ from common.
${ }^{6}$ The AD745 does not exhibit an output phase reversal when the negative common-mode limit is exceeded.
All min and max specifications are guaranteed.
Specifications subject to change without notice.
ABSOLUTE MAXIMUM RATINGS ${ }^{1}$
Supply Voltage ..... $\pm 18 \mathrm{~V}$
Internal Power Dissipation ${ }^{2}$
Plastic Package ..... 1.3 W
Cerdip Package ..... 1.1 W
SOIC Package ..... 1.2 W
Input Voltage ..... $\pm \mathrm{V}_{\mathrm{s}}$
Output Short Circuit Duration ..... Indefinite
Differential Input Voltage
$+V_{S}$ and $-V_{S}$
Storage Temperature Range (Q) $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Storage Temperature Range (N, R) ..... $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Operating Temperature Range
AD745J/K $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
AD745A/B ..... $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
AD745S $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$

## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2} 8$-pin plastic package: $\theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} / \mathrm{Watt}, \theta_{\mathrm{JC}}=50^{\circ} \mathrm{C} / \mathrm{W}$ att
8 -pin cerdip package: $\theta_{\mathrm{JA}}=110^{\circ} \mathrm{C} / \mathrm{W}$ att, $\theta_{\mathrm{JC}}=30^{\circ} \mathrm{C} / \mathrm{Watt}$
16 -pin plastic SOIC package: $\theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} / \mathrm{Watt}, \theta_{\mathrm{JC}}=30^{\circ} \mathrm{C} / \mathrm{Watt}$

## ESD SUSCEPTIBILITY

An ESD classification per method 3015.6 of MIL STD 883C has been performed on the AD745, which is a class 1 device. Using an IMCS 5000 automated ESD tester, the two null pins will pass at voltages up to 1000 volts, while all other pins will pass at voltages exceeding 2500 volts.


ORDERING GUIDE

| Model | Temperature Range | Package <br> Options |
| :--- | :--- | :--- |
| AD745JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| AD745KN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| AD745AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| AD745JR-16 | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{R}-16$ |
| AD745AR-16 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16$ |
| AD745AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |
| AD745BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |
| AD745SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |
| AD745SQ/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |
| AD745J Chips | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ |  |

* $\mathrm{N}=$ Plastic DIP; $\mathbf{R}=$ Small Outline IC; $\mathbf{Q}=$ Cerdip. For outline information see Package Information section.


## FEATURES

AC PERFORMANCE
500 ns Settling to $\mathbf{0 . 0 1 \%}$ for 10 V Step
75 V/us Slew Rate
0.0001\% Total Harmonic Distortion (THD)

13 MHz Gain Bandwidth
Internal Compensation for Gains of $\mathbf{+ 2}$ or Greater
DC PERFORMANCE
0.5 mV max Offset Voltage (AD746B)
$10 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ max Drift (AD746B)
$175 \mathrm{~V} / \mathrm{mV}$ min Open Loop Gain (AD746B)
$2 \mu \mathrm{~V}$ p-p Noise, 0.1 Hz to 10 Hz
Available in Plastic Mini-DIP, Cerdip and Surface Mount Packages
Available in Tape and Reel in Accordance with EIA-481A Standard
MIL-STD-883B Processing also Available
Single Version: AD744

## APPLICATIONS

Dual Output Buffers for 12- and 14-Bit DACs Input Buffers for Precision ADCs, Wideband Preamplifiers and Low Distortion Audio Circuitry

## PRODUCT DESCRIPTION

The AD746 is a dual operational amplifier, consisting of two AD744 BiFET op amps on a single chip. These precision monolithic op amps offer excellent dc characteristics plus rapid settling times, high slew rates and ample bandwidths. In addition, the AD746 provides the close matching ac and dc characteristics inherent to amplifiers sharing the same monolithic die.
The single pole response of the AD746 provides fast settling: 500 ns to $0.01 \%$. This feature, combined with its high dc precision, makes it suitable for use as a buffer amplifier for 12- or 14-bit DACs and ADCs. Furthermore, the AD746's low total harmonic distortion (THD) level of $0.0001 \%$ and very close matching ac characteristics make it an ideal amplifier for many demanding audio applications.

The AD746 is internally compensated for stable operation as a unity gain inverter or as a noninverting amplifier with a gain of 2 or greater. It is available in four performance grades. The AD746J is rated over the commercial temperature range of 0 to $+70^{\circ} \mathrm{C}$. The AD746A and AD746B are rated over the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. The AD746S is rated over the military temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ and is available processed to MIL-STD-883B, Rev. C.

## CONNECTION DIAGRAM

Plastic Mini-DIP (N)
Cerdip (Q) and
Plastic SOIC (R) Packages


The AD746 is available in three 8 -pin packages: plastic miniDIP, hermetic cerdip and surface mount (SOIC).

## PRODUCT HIGHLIGHTS

1. The AD746 offers exceptional dynamic response for high speed data acquisition systems. It settles to $0.01 \%$ in 500 ns and has a $100 \%$ tested minimum slew rate of $50 \mathrm{~V} / \mu \mathrm{s}$ (AD746B).
2. Outstanding dc precision is provided by a combination of Analog Devices' advanced processing technology, laser wafer drift trimming and well-matched ion-implanted JFETs. Input offset voltage, input bias current and input offset current are specified in the warmed-up condition and are $100 \%$ tested.
3. Differential and multichannel systems will benefit from the AD746's very close matching of ac characteristics. Input offset voltage specs are fully tested and guaranteed to a maximum of 0.5 mV (AD746B).
4. The AD746 has very close, guaranteed matching of input bias current between its two amplifiers.
5. Unity gain stable version AD712 also available.
[^136]AD746-SPECIFICATIONS
(@ $+25^{\circ} \mathrm{C}$ and $\pm 15 \mathrm{~V}$ dc, unless otherwise noted)


## NOTES

${ }^{1}$ Input Offset Voltage specifications are guaranteed after 5 minutes of operation at $T_{A}=+25^{\circ} \mathrm{C}$.
${ }^{2}$ PSRR test conditions: $+\mathrm{V}_{\mathrm{S}}=15 \mathrm{~V},-\mathrm{V}_{\mathrm{S}}=-12 \mathrm{~V}$ to -18 V and $+\mathrm{V}_{\mathrm{S}}=12 \mathrm{~V}$ to $18 \mathrm{~V},-\mathrm{V}_{\mathrm{S}}=-15 \mathrm{~V}$.
${ }^{3}$ Bias Current Specifications are guaranteed maximum at either input after 5 minutes of operation at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. For higher temperature, the current doubles every $10^{\circ} \mathrm{C}$.
${ }^{4} \mathrm{Gain}=-1, \mathrm{Rl}=2 \mathrm{k}, \mathrm{Cl}=10 \mathrm{pF}$
${ }^{5}$ Defined as voltage between inputs, such that neither exceeds $\pm 10 \mathrm{~V}$ from ground.
${ }^{6}$ Typically exceeding -14.1 V negative common-mode voltage on either input results in an output phase reversal.
${ }^{7}$ For outline information see Package Information section.
Specifications subject to change without notice.
Specifications in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 18$ V Internal Power Dissipation ${ }^{2}$. . . . . . . . . . . . . . . . . . 500 mW Input Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm \mathrm{V}_{\mathrm{S}}$ Output Short Circuit Duration
(For One Amplifier) . . . . . . . . . . . . . . . . . . . . Indefinite
Differential Input Voltage . . . . . . . . . . . . . . $+V_{S}$ and $-V_{S}$
Storage Temperature Range (Q) . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Storage Temperature Range (N, R) . . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Operating Temperature Range
AD746J . . . . . . . . . . . . . . . . . . . . . . . . . . . . 0 to $+70^{\circ} \mathrm{C}$
AD746A/B . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$

AD746S . . . . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Lead Temperature Range
(Soldering 60 seconds) . . . . . . . . . . . . . . . . . . . . $+300^{\circ} \mathrm{C}$

## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2} 8$-Pin Plastic Package: $\theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} / \mathrm{Watt}, \theta_{\mathrm{JC}}=50^{\circ} \mathrm{C} / \mathrm{W}$ att
8 -Pin Cerdip Package: $\theta_{\mathrm{JA}}=110^{\circ} \mathrm{C} / \mathrm{Watt}, \theta_{\mathrm{JC}}=30^{\circ} \mathrm{C} /$ Watt
8 -Pin Small Outline Package: $\theta_{\mathrm{JA}}=160^{\circ} \mathrm{C} / \mathrm{W}$ att, $\theta_{\mathrm{JC}}=42^{\circ} \mathrm{C} / \mathrm{Watt}$

## METALIZATION PHOTOGRAPH

Contact factory for latest dimensions.
Dimensions shown in inches and (mm).


## FEATURES

## Low Power Replacement for Burr-Brown <br> OPA-111, OPA-121 Op Amps

## Low Noise

$2.5 \mu \mathrm{~V}$ p-p max, 0.1 Hz to 10 Hz $11 \mathrm{nV} / \sqrt{\mathrm{Hz}} \max$ at 10 kHz $0.6 \mathrm{fA} / \sqrt{\mathrm{Hz}}$ at 1 kHz
High DC Accuracy
$250 \mu \mathrm{~V}$ max Offset Voltage
$3 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ max Drift
1 pA max Input Bias Current
Low Power: 1.5 mA Max Supply Current
Available in Low Cost Plastic Mini-DIP and Surface
Mount (SOIC) Packages

## APPLICATIONS

Low Noise Photodiode Preamps

## CT Scanners

Precision I-to-V Converters

## PRODUCT DESCRIPTION

The AD795 is a low noise, precision, FET input operational amplifier. It offers both the low voltage noise and low offset drift of a bipolar input op amp and the very low bias current of a FET-input device. The $10^{14} \Omega$ common-mode impedance insures that input bias current is essentially independent of common-mode voltage and supply voltage variations.
The AD795 has both excellent dc performance and a guaranteed and tested maximum input voltage noise. It features 1 pA maximum input bias current and $250 \mu \mathrm{~V}$ maximum offset voltage, along with low supply current of 1.5 mA max.

AD795 Voltage Noise Spectral Density

## CONNECTION DIAGRAMS

8-Pin Plastic Mini-DIP (N) Packages


8-Pin SOIC (R) Package


Furthermore, the AD795 features a guaranteed low input noise of $2.5 \mu \mathrm{~V} \mathrm{p}-\mathrm{p}(0.1 \mathrm{~Hz}$ to 10 Hz ) and a $11 \mathrm{nV} / \sqrt{\mathrm{Hz}} \max$ noise level at 10 kHz . The AD795 has a fully specified and tested input offset voltage drift of only $3 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ max.
The AD795 is useful for many high input impedance, low noise applications. The AD795J and AD795K are rated over the commercial temperature range of $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$.
The AD795 is available in 8-pin plastic mini-DIP and 8-pin surface mount (SOIC) packages.


Typical Distribution of Average Input Offset Voltage Drift

|  |  | AD795JN/JR |  |  | AD795K |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Parameter | Conditions | Min | Typ | Max | Min | Typ | Max |  |
| INPUT OFFSET VOLTAGE ${ }^{1}$ |  |  |  |  |  |  |  |  |
| Initial Offset |  |  | 100 | 500 |  | 50 | 250 | $\mu \mathrm{V}$ |
| Offset | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ |  | 300 | 1000 |  | 100 | 400 | $\mu \mathrm{V}$ |
| vs. Temperature |  |  | 3 | 10 |  | 1 | 3 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| vs. Supply (PSRR) |  | 86 | 110 |  | 90 | 110 |  | dB |
| vs. Supply (PSRR) | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ | 84 | 100 |  | 87 | 100 |  | dB |
| INPUT BIAS CURRENT ${ }^{2}$ |  |  |  |  |  |  |  |  |
| Either Input | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ |  | 1 | 2/3 |  | 1 | 1 | pA |
| Either Input @ $\mathrm{T}_{\text {MAX }}=$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ |  | 23 |  |  | 23 |  | pA |
| Either Input | $\mathrm{V}_{\mathrm{CM}}=+10 \mathrm{~V}$ |  | 1 |  |  | 1 |  | pA |
| Offset Current | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ |  | 0.1 | 1.0 |  | 0.1 | 0.5 | pA |
| Offset Current @ $\mathrm{T}_{\text {MAX }}=$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ |  | 2 |  |  | 2 |  | pA |
| OPEN-LOOP GAIN | $\mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V}$ |  |  |  |  |  |  |  |
|  | $\mathrm{R}_{\text {LOAD }} \geq 10 \mathrm{k} \Omega$ | 110 | 120 |  | 110 | 120 |  | dB |
|  | $\mathrm{R}_{\text {LOAD }} \geq 10 \mathrm{k} \Omega$ | 100 | 108 |  | 100 | 108 |  | dB |
| INPUT VOLTAGE NOISE | 0.1 Hz to 10 Hz |  | 1.0 | 3.3 |  | 1.0 | 2.5 | $\mu \mathrm{V}$ p-p |
|  | $\mathrm{f}=10 \mathrm{~Hz}$ |  | 20 | 50 |  | 20 | 40 | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
|  | $\mathrm{f}=100 \mathrm{~Hz}$ |  | 12 | 40 |  | 12 | 30 | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
|  | $\mathrm{f}=1 \mathrm{kHz}$ |  | 11 | 17 |  | 11 | 15 | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
|  | $\mathrm{f}=10 \mathrm{kHz}$ |  | 9 | 11 |  | 9 | 11 | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| INPUT CURRENT NOISE | $\mathrm{f}=0.1 \mathrm{~Hz}$ to 10 Hz |  | 13 |  |  | 13 |  | fA p-p |
|  | $\mathrm{f}=1 \mathrm{kHz}$ |  | 0.6 |  |  | 0.6 |  | $\mathrm{fA} / \sqrt{\mathrm{Hz}}$ |
| FREQUENCY RESPONSE |  |  |  |  |  |  |  |  |
| Unity Gain, Small Signal Full Power Response | $\mathrm{G}=-1$ |  | 1.6 |  |  | 1.6 |  | MHz |
|  | $\mathrm{V}_{\mathrm{O}}=20 \mathrm{~V}$ p-p |  |  |  |  |  |  |  |
| Slew Rate, Unity Gain | $\mathrm{R}_{\text {LOAD }}=2 \mathrm{k} \Omega$ |  | 16 |  |  | 16 |  | kHz |
|  | $\mathrm{V}_{\text {OUT }}=20 \mathrm{~V}$ p-p |  |  |  |  |  |  |  |
|  | $\mathrm{R}_{\text {LOAD }}=2 \mathrm{k} \Omega$ |  | 1 |  |  | 1 |  | V/us |
| SETTLING TIME ${ }^{3}$ |  |  |  |  |  |  |  |  |
| To 0.1\% | 10 V Step |  | 10 |  |  | 10 |  | $\mu s$ |
| To 0.01\% | 10 V Step |  | 11 |  |  | 11 |  | $\mu \mathrm{s}$ |
| Overload Recovery ${ }^{4}$ | 50\% Overdrive |  | 2 |  |  | 2 |  | $\mu \mathrm{s}$ |
| Total Harmonic | $\mathrm{f}=1 \mathrm{kHz}$ |  |  |  |  |  |  |  |
| Distortion | $\mathrm{Rl} \geq 10 \mathrm{k} \Omega$ |  |  |  |  |  |  |  |
|  | $\mathrm{V}_{\mathrm{O}}=3 \mathrm{Vrms}$ |  | -108 |  |  | -108 |  | dB |
| INPUT IMPEDANCE |  |  |  |  |  |  |  |  |
| Differential | $\mathrm{V}_{\text {DIFF }}= \pm 1 \mathrm{~V}$ |  | $10^{12}\| \| 2$ |  |  | $10^{12}\| \| 2$ |  | $\Omega \\| \mathrm{pF}$ |
| Common Mode |  |  | $10^{14} \mid 2.2$ |  |  | $10^{14} \mid 2.2$ |  | $\Omega \\| \mathrm{pF}$ |
| INPUT VOLTAGE RANGE |  |  |  |  |  |  |  |  |
| Differential ${ }^{5}$ |  |  | $\pm 20$ |  |  | $\pm 20$ |  | V |
| Common-Mode Voltage |  | $\pm 10$ | $\pm 11$ |  | $\pm 10$ | $\pm 11$ |  | V |
| Over Max Operating Temperature |  | $\pm 10$ |  |  | $\pm 10$ |  |  | V |
| Common-Mode Rejection Ratio | $\mathrm{V}_{\mathrm{CM}}= \pm 10 \mathrm{~V}$ | 90 | 110 |  | 94 | 110 |  | dB |
|  | $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ | 86 | 100 |  | 90 | 100 |  | dB |
| OUTPUT CHARACTERISTICS |  |  |  |  |  |  |  |  |
| Voltage | $\mathrm{R}_{\text {LOAD }} \geq 2 \mathrm{k} \Omega$ | $\mathrm{V}_{\mathrm{S}}-4$ | $\mathrm{V}_{\mathrm{S}}-2.5$ |  | $\mathrm{V}_{\mathrm{s}}-4$ | $\mathrm{V}_{\mathrm{S}}-2.5$ |  | V |
|  | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ | $\mathrm{V}_{\mathrm{s}}-4$ |  |  | $\mathrm{V}_{\mathrm{s}}-4$ |  |  | V |
| Current | $\mathrm{V}_{\text {OUT }}= \pm 10 \mathrm{~V}$ | $\pm 5$ | $\pm 10$ |  | $\pm 5$ | $\pm 10$ |  | mA |
|  | Short Circuit |  | $\pm 15$ |  |  | $\pm 15$ |  | mA |
| POWER SUPPLY |  |  |  |  |  |  |  |  |
| Rated Performance |  |  | $\pm 15$ |  |  | $\pm 15$ |  | V |
| Operating Range |  | $\pm 4$ |  | $\pm 18$ | $\pm 4$ |  | $\pm 18$ | V |
| Quiescent Current |  |  | 1.3 | 1.5 |  | 1.3 | 1.5 | mA |

## AD795

NOTES
${ }^{1}$ Input offset voltage specifications are guaranteed after 5 minutes of operation at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.
${ }^{2}$ Bias current specifications are guaranteed maximum at either input after 5 minutes of operation at $T_{A}=+25^{\circ} \mathrm{C}$. For higher temperature, the current doubles every $10^{\circ} \mathrm{C}$.
${ }^{3}$ Gain $=-1, \mathrm{Rl}=10 \mathrm{k} \Omega$.
${ }^{4}$ Defined as the time required for the amplifier's output to return to normal operation after removal of a $50 \%$ overload from the amplifier input.
${ }^{5}$ Defined as the maximum continuous voltage between the inputs such that neither input exceeds $\pm 10 \mathrm{~V}$ from ground.
All min and max specifications are guaranteed.
Specifications subject to change without notice.

| ABSOLUTE MAXIMUM RATINGS ${ }^{\mathbf{1}}$ |  |
| :---: | :---: |
| Supply Voltage | V |
| Internal Power Dissipation ${ }^{2}$ ( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ ) |  |
| SOIC Package | 500 mW |
| 8-Pin Mini-DIP Package | 750 mW |
| Input Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm \mathrm{V}_{\text {S }}$ |  |
| Output Short Circuit Duration . . . . . . . . . . . . . . . Indefinite |  |
| Differential Input Voltage . . . . . . . . . . . . $+\mathrm{V}_{\text {S }}$ and $-\mathrm{V}_{\text {S }}$ |  |
| Storage Temperature Range ( $\mathrm{N}, \mathrm{R}$ ) . . . . . $-65^{\circ} \mathrm{C}$ to +12 |  |
| Operating Temperature Range |  |
| AD795J/K | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ |

## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2} 8$-Pin Plastic Mini-DIP Package: $\theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} /$ Watt
8-Pin Small Outline Package: $\theta_{\mathrm{JA}}=155^{\circ} \mathrm{C} / \mathrm{Watt}$

## ESD SUSCEPTIBILITY

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 volts, which readily accumulate on the human body and on test equipment, can discharge without detection. Although the AD795 features proprietary ESD protection circuitry, permanent damage may still occur on these devices if they are subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid any performance degradation or loss of functionality.

## ORDERING GUIDE

| Model | Temperature Range | Package Option |
| :--- | :--- | :--- |
| AD795JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| AD795KN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| AD795JR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{R}-8$ |

${ }^{\star} \mathrm{N}=$ Plastic mini-DIP; R = SOIC package. For outline information see Package Information section.


Figure 1. Common-Mode Voltage Range vs. Supply


Figure 3. Output Voltage Swing vs. Load Resistance


Figure 5. Typical Distribution of Input Bias Current


Figure 2. Output Voltage Range vs. Supply Voltage


Figure 4. Input Bias Current vs. Supply


Figure 6. Input Bias Current vs. Temperature

## AD795 - Typical Characteristics



Figure 7. Input Bias Current vs. Common-Mode Voltage


Figure 9. Voltage and Current Noise Spectral Density vs. Temperature


Figure 11. Typical Distribution of Input Voltage Noise


Figure 8. Input Bias Current vs. Differential Input Voltage


Figure 10. Input Voltage Noise vs. Source Resistance


Figure 12. Input Voltage Noise Spectral Density


Figure 13. Short Circuit Current Limit vs. Temperature


Figure 15. Absolute Input Error Voltage vs. Input Common-Mode Voltage


Figure 17. Common-Mode Rejection vs. Frequency


Figure 14. Output Swing and Error vs. Settling Time


Figure 16. Power Supply Rejection vs. Frequency


Figure 18. Open-Loop Gain \& Phase Margin vs. Frequency


Figure 19. Large Signal Frequency Response


Figure 21. Total Harmonic Distortion vs. Frequency


Figure 20. Closed-Loop Output Impedance vs. Frequency


Figure 22. Quiescent Supply Current vs. Supply Voltage Drift


Figure 23. Typical Distribution of Input Offset Voltage


Figure 24. Unity Gain Inverter


Figure 27. Unity Gain Follower


Figure 25. Unity Gain Inverter Large Signal Pulse Response


Figure 28. Unity Gain Follower Large Signal Pulse Response


Figure 26. Unity Gain Inverter Small Signal Pulse Response


Figure 29. Unity Gain Follower Small Signal Pulse Response

## MINIMIZING INPUT CURRENT

The AD795 is guaranteed to 1 pA max input current with $\pm 15$ volt supply voltage at room temperature. Careful attention to how the amplifier is used will maintain or possibly better this performance.
The amplifier's operating temperature should be kept as low as possible. Like other JFET input amplifier's, the AD795's input
current will double for every $10^{\circ} \mathrm{C}$ rise in junction temperature (illustrated in Figure 6). On-chip power dissipation will raise the device operating temperature, causing an increase in input current. Reducing supply voltage to cut power dissipation will reduce the AD795's input current (Figure 4). Heavy output loads can also increase chip temperature, maintaining a minimum load resistance of $10 \mathrm{k} \Omega$ in recommended.

## AD795

## CIRCUIT BOARD NOTES

The AD795 is designed for throughhole mounting on PC boards, using either mini-DIP or surface mount (SOIC). Maintaining picoampere resolution in those environments requires a lot of care. Both the board and the amplifier's package have finite resistance. Voltage differences between the input pins and other pins as well as PC board metal traces will cause parasitic currents (Figure 30) larger than the AD795's input current unless special precautions are taken. Two methods of minimizing parasitic leakages are guarding of the input lines and maintaining adequate insulation resistance.
Figures 31 and 32 show the recommended guarding schemes for follower and inverted topologies. Note that for the mini-DIP, the guard trace should be on both sides of the board. On the SOIC, Pin 1 is not connected, and can be safely connected to the guard. The high impedance input trace should be guarded on both edges for its entire length.


Figure 30. Sources of Parasitic Leakage Currents


Figure 31. Guarding Scheme-Inverter


Figure 32. Guard Scheme-Follower

Leakage through the bulk of the circuit board will still occur with the guarding schemes shown in Figures 31 and 32. Standard "G10" type printed circuit board material may not have high enough volume resistivity to hold leakages at the subpicoampere level particularly under high humidity conditions. One option that eliminates all effects of board resistance is shown in Figure 33. The AD795's sensitive input pin (either Pin 2 when connected as an inverter, or Pin 3 when connected as a follower) is bent up and soldered directly to a Teflon ${ }^{\star}$ insulated standoff. Both the signal input and feedback component leads must also be insulated from the circuit board by Teflon standoffs or low-leakage shielded cable.


Figure 33. Input Pin to Insulating Standoff
Contaminants such as solder flux on the board's surface and on the amplifier's package can greatly reduce the insulation resistance between the input pin and those traces with supply or signal voltages. Both the package and the board must be kept clean and dry. An effective cleaning procedure is to first swab the surface with high grade isopropyl alcohol, then rinse it with deionized water and, finally, bake it at $100^{\circ} \mathrm{C}$ for 1 hour. Polypropylene and polystyrene capacitors should not be subjected to the $100^{\circ} \mathrm{C}$ bake as they will be damaged at temperatures greater than $80^{\circ} \mathrm{C}$.
Other guidelines include making the circuit layout as compact as possible and reducing the length of input lines. Keeping circuit board components rigid and minimizing vibration will reduce triboelectric and piezoelectric effects. All precision high impedance circuitry requires shielding from electrical noise and interference. For example, a ground plane should be used under all high value (i.e., greater than $1 \mathrm{M} \Omega$ ) feedback resistors. In some cases, a shield placed over the resistors, or even the entire amplifier, may be needed to minimize electrical interference originating from other circuits. Referring to the equation in Figure 30, this coupling can take place in either, or both, of two different forms-coupling via time varying fields:

$$
\frac{d V}{d T} C_{P}
$$

or by injection of parasitic currents by changes in capacitance due to mechanical vibration:

$$
\frac{d C p}{d t} V
$$

[^137]Both proper shielding and rigid mechanical mounting of components help minimize error currents from both of these sources.

## OFFSET NULLING

The AD795's input offset voltage can be nulled (mini-DIP package only) by using balance Pins 1 and 5, as shown in Figure 34. Nulling the input offset voltage in this fashion will introduce an added input offset voltage drift component of $2.4 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ per millivolt of nulled offset.


Figure 34. Standard Offset Null Circuit
The circuit in Figure 35 can be used when the amplifier is used as an inverter. This method introduces a small voltage in series with the amplifier's positive input terminal. The amplifier's input offset voltage drift with temperature is not affected. However, variation of the power supply voltages will cause offset shifts.


Figure 35. Alternate Offset Null Circuit for Inverter
s.


Igure 35. Alt

## AD795

## AC RESPONSE WITH HIGH VALUE SOURCE AND FEEDBACK RESISTANCE

Source and feedback resistances greater than $100 \mathrm{k} \Omega$ will magnify the effect of input capacitances (stray and inherent to the AD795) on the ac behavior of the circuit. The effects of commonmode and differential input capacitances should be taken into account since the circuit's bandwidth and stability can be adversely affected.
In a follower, the source resistance, $\mathbf{R}_{s}$, and input commonmode capacitance, $\mathrm{C}_{\mathrm{S}}$ (including capacitance due to board and capacitance inherent to the AD795), form a pole that limits circuit bandwidth to $1 / 2 \pi R_{s} C_{s}$. Figure 36 shows the follower pulse response from a $1 \mathrm{M} \Omega$ source resistance with the amplifier's input pin isolated from the board, only the effect of the AD795's input common-mode capacitance is seen.


Figure 36. Follower Pulse Response from $1 M \Omega$ Source Resistance

In an inverting configuration, the differential input capacitance forms a pole in the circuit's loop transmission. This can create peaking in the ac response and possible instability. A feedback capacitance can be used to stabilize the circuit. The inverter pulse response with $R_{F}$ and $R_{S}$ equal to $1 M \Omega$, and the input pin isolated from the board appears in Figure 37. Figure 38 shows the response of the same circuit with a 1 pF feedback capacitance. Typical differential input capacitance for the AD795 is 2 pF .


Figure 37. Inverter Pulse Response with $1 \mathrm{M} \Omega$ Source and Feedback Resistance


Figure 38. Inverter Pulse Response with $1 \mathrm{M} \Omega$ Source and Feedback Resistance, 1 pF Feedback Capacitance

## OVERLOAD ISSUES

Driving the amplifier output beyond its linear region causes some sticking; recovery to normal operation is within $2 \mu$ s of the input voltage returning within the linear range.
If either input is driven below the negative supply, the amplifier's output will be driven high, causing a phenomenon called phase reversal. Normal operation is resumed within $30 \mu$ s of the input voltage returning within the linear range.
Figure 39 shows the AD795's input currents versus differential input voltage. Picoamp level input current is maintained for differential voltages up to several hundred millivolts. This behavior is only important if the AD795 is in an open-loop application where substantial differential voltages are produced.


Figure 39. Input Bias Current vs. Differential Input Voltage

## INPUT PROTECTION

The AD795 safely handles any input voltage within the supply voltage range. Some applications may subject the input terminals to voltages beyond the supply voltages-in these cases, the following guidelines should be used to maintain the AD795's functionality and performance.
If the inputs are driven more than a 0.5 V below the minus supply, milliamp level currents can be produced through the input terminals. That current should be limited to 10 mA for "transient" overloads (less than 1 second) and 1 mA for continuous overloads, this can be accomplished with a protection resistor in the input terminal (as shown in Figures 40 and 41). The protection resistor's Johnson noise will add to the amplifier's input voltage noise and impact the frequency response.
Driving the input terminals above the positive supply will cause the input current to increase and limit at $40 \mu \mathrm{~A}$. This condition is maintained until 15 volts above the positive supply-any input voltage within this range does not harm the amplifier. Input voltage above this range causes destructive breakdown and should be avoided.


Figure 40. Inverter with Input Current Limit


Figure 41. Follower with Input Current Limit
Figure 42 is a schematic of the AD795 as an inverter with an input voltage clamp. Bootstrapping the clamp diodes at the inverting input minimizes the voltage across the clamps and keeps the leakage due to the diodes low. Low leakage diodes (less than 1 pA ), such as the FD333's should be used, and should be shielded from light to keep photocurrents from being generated. Even with these precautions, the diodes will measurably increase the input current and capacitance.
In order to achieve the low input bias currents of the AD795, it is not possible to use the same on-chip protection as used in other Analog Devices op amps. This makes the AD795 sensitive to handling and precautions should be taken to minimize ESD exposure whenever possible.


Figure 42. Input Voltage Clamp with Diodes


Figure 43. The AD795 Used as a Photodiode Preamplifier

## Preamplifier Applications

The low input current and offset voltage levels of the AD795 together with its low voltage noise make this amplifier an excellent choice for preamplifiers used in sensitive photodiode applications. In a typical preamp circuit, shown in Figure 43, the output of the amplifier is equal to:

$$
V_{O U T}=I_{D}(R f)=R p(P) R f
$$

where:

$$
I_{D}=\text { photodiode signal current }(\mathrm{Amps})
$$

$\mathrm{Rp}=$ photodiode sensitivity (Amp/Watt)
Rf $=$ the value of the feedback resistor, in ohms.
$\mathbf{P}=$ light power incident to photodiode surface, in watts.
An equivalent model for a photodiode and its dc error sources is shown in Figure 44. The amplifier's input current, $I_{B}$, will contribute an output voltage error which will be proportional to the value of the feedback resistor. The offset voltage error, $\mathrm{V}_{\mathrm{OS}}$, will cause a "dark" current error due to the photodiode's finite shunt resistance, Rd . The resulting output voltage error, $\mathrm{V}_{\mathrm{E}}$, is equal to:

$$
V_{E}=(l+R f / R d) V_{O S}+R f I_{B}
$$

A shunt resistance on the order of $10^{9}$ ohms is typical for a small photodiode. Resistance Rd is a junction resistance which


Figure 44. A Photodiode Model Showing DC Error Sources
will typically drop by a factor of two for every $10^{\circ} \mathrm{C}$ rise in temperature. In the AD795, both the offset voltage and drift are low, this helps minimize these errors.

## Minimizing Noise Contributions

The noise level limits the resolution obtainable from any preamplifier. The total output voltage noise divided by the feedback resistance of the op amp defines the minimum detectable signal current. The minimum detectable current divided by the photodiode sensitivity is the minimum detectable light power.
Sources of noise in a typical preamp are shown in Figure 45. The total noise contribution is defined as:

$$
\overline{V_{O U \bar{r}}}=\sqrt{\left(\bar{i}_{n}^{2}+\bar{i}_{f}^{2}+\bar{i}_{s}^{2}\right)\left(\frac{R f}{1+s(C f) R f}\right)^{2}+\left(\overline{e n^{2}}\right)\left(1+\frac{R f}{R d}\left(\frac{1+s(C d) R d}{1+s(C f) R f}\right)\right)^{2}}
$$



Figure 45. Noise Contributions of Various Sources
Figure 46, a spectral density versus frequency plot of each source's noise contribution, shows that the bandwidth of the amplifier's input voltage noise contribution is much greater than its signal bandwidth. In addition, capacitance at the summing junction results in a "peaking" of noise gain in this configuration. This effect can be substantial when large photodiodes with large shunt capacitances are used. Capacitor Cf sets the signal bandwidth and also limits the peak in the noise gain. Each source's rms or root-sum-square contribution to noise is obtained by integrating the sum of the squares of all the noise sources and then by obtaining the square root of this sum. Minimizing the total area under these curves will optimize the preamplifier's overall noise performance.
An output filter with a passband close to that of the signal can greatly improve the preamplifier's signal to noise ratio. The photodiode preamplifier shown in Figure 45-without a bandpass filter-has a total output noise of $50 \mu \mathrm{~V}$ rms. Using a 26 Hz single pole output filter, the total output noise drops to $23 \mu \mathrm{~V} \mathrm{rms}$, a factor of 2 improvement with no loss in signal bandwidth.


Figure 46. Voltage Noise Spectral Density of the Circuit of Figure 45 with and without an Output Filter


Figure 47. A Photodiode Preamp Employing a " $T$ " Network for Added Gain

## Using a "T" Network

A "T" network, shown in Figure 47, can be used to boost the effective transimpedance of an I to V converter, for a given feedback resistor value. However, amplifier noise and offset
voltage contributions are also amplified by the " T " network gain. A low noise, low offset voltage amplifier, such as the AD795, is needed for this type of application.

## A pH Probe Buffer Amplifier

A typical pH probe requires a buffer amplifier to isolate its $10^{6}$ to $10^{9} \Omega$ source resistance from external circuitry. Just such an amplifier is shown in Figure 48. The low input current of the AD795 allows the voltage error produced by the bias current and electrode resistance to be minimal. The use of guarding, shielding, high insulation resistance standoffs, and other such standard methods used to minimize leakage are all needed to maintain the accuracy of this circuit.
The slope of the pH probe transfer function, 50 mV per pH unit at room temperature, has a $+3300 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ temperature coefficient. The buffer of Figure 48 provides an output voltage equal to $1 \mathrm{volt} / \mathrm{pH}$ unit. Temperature compensation is provided by resistor RT which is a special temperature compensation resistor, part number $\mathrm{Q} 81,1 \mathrm{k} \Omega, 1 \%,+3500 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$, available from Tel Labs Inc.


Figure 48. A pH Probe Amplifier

# Ultralow Distortion, Ultralow Noise Op Amp 

## FEATURES

Low Noise
$0.9 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ typ ( $1.2 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ max) Input Voltage Noise at 1 kHz
50 nV p-p Input Voltage Noise, 0.1 to $10 \mathbf{~ H z}$
Low Distortion

- 120 dB Total Harmonic Distortion at 20 kHz

Excellent AC Characteristics
800 ns Settling Time to 16 Bits (10 V Step)
110 MHz Gain Bandwidth $(G=1000)$
8 MHz Bandwidth ( $G=10$ )
280 kHz Full Power Bandwidth at 20 V p-p 20 V/ $\mu$ s Slew Rate
Excellent DC Precision
$80 \mu \mathrm{~V}$ max Input Offset Voltage
$1.0 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C} \mathrm{V}_{\text {os }}$ Drift
Specified for $\pm 5$ V and $\pm 15$ V Power Supplies
High Output Drive Current of $\mathbf{5 0} \mathbf{~ m A}$

## APPLICATIONS

Professional Audio Preamplifiers
IR, CCD, and Sonar Imaging Systems
Spectrum Analyzers
Ultrasound Preamplifiers

## Seismic Detectors

## $\boldsymbol{\Sigma} \triangle$ ADC/DAC Buffers

## PRODUCT DESCRIPTION

The AD797 is a very low noise, low distortion operational amplifier ideal for use as a preamplifier. The low noise of $0.9 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ and low total harmonic distortion of -120 dB at audio bandwidths give the AD797 the wide dynamic range


AD797 Voltage Noise Spectral Density

## CONNECTION DIAGRAM

8-Pin Plastic Mini-DIP (N), Cerdip (Q) and SOIC (R)

Packages

necessary for preamps in microphones and mixing consoles. Furthermore, the AD797's excellent slew rate of $20 \mathrm{~V} / \mu \mathrm{s}$ and 110 MHz gain bandwidth make it highly suitable for low frequency ultrasound applications.
The AD797 is also useful in IR and Sonar Imaging applications where the widest dynamic range is necessary. The low distortion and 16 -bit settling time of the AD797 make it ideal for buffering the inputs to $\Sigma \Delta$ ADCs or the outputs of high resolution DACs especially when they are used in critical applications such as seismic detection and spectrum analyzers. Key features such as a 50 mA output current drive and the specified power supply voltage range of $\pm 5$ to $\pm 15$ volts make the AD797 an excellent general purpose amplifier.


THD vs. Frequency

[^138]SPECIFICATIONS
$\left(@ T_{A}=+25^{\circ} C\right.$ and $V_{S}= \pm 15 \mathrm{~V} d c$, unless otherwise noted)

| Model | Conditions | $\mathbf{V}_{\text {s }}$ | AD797A/S ${ }^{1}$ |  |  | AD797B |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max | Min | Typ | Max |  |
| INPUT OFFSET VOLTAGE Offset Voltage Drift | $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ | $\begin{aligned} & \pm 5 \mathrm{~V}, \pm 15 \mathrm{~V} \\ & \pm 5 \mathrm{~V}, \pm 15 \mathrm{~V} \end{aligned}$ |  | $\begin{aligned} & 25 \\ & 50 \\ & 0.2 \end{aligned}$ | $\begin{aligned} & \hline 80 \\ & 125 / 180 \\ & 1.0 \end{aligned}$ |  | $\begin{aligned} & 10 \\ & 30 \\ & 0.2 \end{aligned}$ | $\begin{aligned} & 40 \\ & 60 \\ & 0.6 \end{aligned}$ | $\mu \mathrm{V}$ $\mu \mathrm{V}$ $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| INPUT BIAS CURRENT | $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ | $\pm 5 \mathrm{~V}, \pm 15 \mathrm{~V}$ |  | $\begin{aligned} & 0.25 \\ & 0.5 \end{aligned}$ | $\begin{aligned} & 1.5 \\ & 3.0 \end{aligned}$ |  | $\begin{aligned} & 0.25 \\ & 0.25 \end{aligned}$ | $\begin{aligned} & 0.9 \\ & 2.0 \end{aligned}$ | $\begin{aligned} & \mu \mathrm{A} \\ & \mu \mathrm{~A} \\ & \hline \end{aligned}$ |
| INPUT OFFSET CURRENT | $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ | $\pm 5 \mathrm{~V}, \pm 15 \mathrm{~V}$ |  | $\begin{aligned} & 100 \\ & 120 \end{aligned}$ | $\begin{aligned} & \hline 400 \\ & 600 / 700 \end{aligned}$ |  | $\begin{aligned} & 80 \\ & 120 \end{aligned}$ | $\begin{aligned} & 200 \\ & 300 \end{aligned}$ | $\begin{aligned} & \mathrm{nA} \\ & \mathrm{nA} \end{aligned}$ |
| OPEN-LOOP GAIN | $\begin{aligned} & \mathrm{V}_{\text {OUT }}= \pm 10 \mathrm{~V} \\ & \mathrm{R}_{\text {LOAD }}=2 \mathrm{k} \Omega \\ & \mathrm{~T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }} \\ & \mathrm{R}_{\text {LOAD }}=600 \Omega \\ & \mathrm{~T}_{\text {MIN }} \text { to } \mathrm{T}_{\text {MAX }} \\ & @ 20 \mathrm{kHz}^{2} \end{aligned}$ | $\pm 15 \mathrm{~V}$ | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 1 \\ & 14000 \end{aligned}$ | $\begin{aligned} & 20 \\ & 6 \\ & 15 \\ & 5 \\ & 20000 \end{aligned}$ |  | $\begin{aligned} & 2 \\ & 2 \\ & 2 \\ & 2 \\ & 14000 \end{aligned}$ | $\begin{aligned} & 20 \\ & 10 \\ & 15 \\ & 7 \\ & 20000 \end{aligned}$ |  | $\begin{aligned} & \mathrm{V} / \mu \mathrm{V} \\ & \mathrm{~V} / \mu \mathrm{V} \\ & \mathrm{~V} / \mu \mathrm{V} \\ & \mathrm{~V} / \mu \mathrm{V} \\ & \mathrm{~V} / \mathrm{V} \end{aligned}$ |
| DYNAMIC PERFORMANCE <br> Gain Bandwidth Product <br> -3 dB Bandwidth <br> Full Power Bandwidth ${ }^{3}$ <br> Slew Rate <br> Settling Time to $0.0015 \%$ | $\begin{aligned} & \mathrm{G}=1000 \\ & \mathrm{G}=1000^{2} \\ & \mathrm{G}=10 \\ & \mathrm{~V}_{\mathrm{O}}=20 \mathrm{~V} \mathrm{p}-\mathrm{p}, \\ & \mathrm{R}_{\mathrm{LOAD}}=1 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{LOAD}}=1 \mathrm{k} \Omega \\ & 10 \mathrm{~V} \text { Step } \end{aligned}$ | $\begin{aligned} & \pm 15 \mathrm{~V} \\ & \pm 15 \mathrm{~V} \\ & \pm 15 \mathrm{~V} \\ & \\ & \pm 15 \mathrm{~V} \\ & \pm 15 \mathrm{~V} \\ & \pm 15 \mathrm{~V} \end{aligned}$ | 12.5 | $\begin{aligned} & 110 \\ & 450 \\ & 8 \\ & \\ & 280 \\ & 20 \\ & 800 \end{aligned}$ | $1200$ | $12.5$ | $\begin{aligned} & 110 \\ & 450 \\ & 8 \\ & \\ & 280 \\ & 20 \\ & 800 \end{aligned}$ | $1200$ | MHz <br> MHz <br> MHz <br> kHz <br> V/ $\mu \mathrm{s}$ <br> ns |
| COMMON-MODE REJECTION | $\begin{aligned} & \mathrm{V}_{\mathrm{CM}}=\mathrm{CMVR} \\ & \mathrm{~T}_{\mathrm{MIN}} \text { to } \mathrm{T}_{\mathrm{MAX}} \end{aligned}$ | $\pm 5 \mathrm{~V}, \pm 15 \mathrm{~V}$ | $\begin{aligned} & 114 \\ & 110 \\ & \hline \end{aligned}$ | $\begin{aligned} & 130 \\ & 120 \end{aligned}$ |  | $\begin{aligned} & 120 \\ & 114 \\ & \hline \end{aligned}$ | $\begin{aligned} & 130 \\ & 120 \end{aligned}$ |  | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \end{aligned}$ |
| POWER SUPPLY REJECTION | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}= \pm 5 \mathrm{~V} \text { to } \pm 18 \mathrm{~V} \\ & \mathrm{~T}_{\text {MIN }} \text { to } \mathrm{T}_{\text {MAX }} \end{aligned}$ |  | $\begin{aligned} & 114 \\ & 110 \\ & \hline \end{aligned}$ | $\begin{aligned} & 130 \\ & 120 \end{aligned}$ |  | $\begin{aligned} & 120 \\ & 114 \\ & \hline \end{aligned}$ | $\begin{aligned} & 130 \\ & 120 \end{aligned}$ |  | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \end{aligned}$ |
| INPUT VOLTAGE NOISE | $\begin{aligned} & \mathrm{f}=0.1 \mathrm{~Hz} \text { to } 10 \mathrm{~Hz} \\ & \mathrm{f}=10 \mathrm{~Hz} \\ & \mathrm{f}=1 \mathrm{kHz} \\ & \mathrm{f}=10 \mathrm{~Hz}-1 \mathrm{MHz} \end{aligned}$ | $\begin{aligned} & \pm 15 \mathrm{~V} \\ & \pm 15 \mathrm{~V} \\ & \pm 15 \mathrm{~V} \\ & \pm 15 \mathrm{~V} \end{aligned}$ |  | $\begin{aligned} & 50 \\ & 1.7 \\ & 0.9 \\ & 1.0 \end{aligned}$ | $\begin{aligned} & 1.2 \\ & 1.3 \end{aligned}$ |  | $\begin{aligned} & 50 \\ & 1.7 \\ & 0.9 \\ & 1.0 \end{aligned}$ | $\begin{aligned} & 2.5 \\ & 1.2 \\ & 1.2 \end{aligned}$ | $\begin{aligned} & \mathrm{nV} \mathrm{p}-\mathrm{p} \\ & \mathrm{nV} / \sqrt{\mathrm{Hz}} \\ & \mathrm{nV} / \sqrt{\mathrm{Hz}} \\ & \mu \mathrm{~V} / \mathrm{rms} \end{aligned}$ |
| INPUT CURRENT NOISE | $\mathrm{f}=1 \mathrm{kHz}$ | $\pm 15 \mathrm{~V}$ |  | 2.0 |  |  | 2.0 |  | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
| INPUT COMMON-MODE VOLTAGE RANGE |  | $\begin{aligned} & \pm 15 \mathrm{~V} \\ & \pm 5 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & \pm 11 \\ & \pm 2.5 \\ & \hline \end{aligned}$ | $\begin{aligned} & \pm 12 \\ & \pm 3 \end{aligned}$ |  | $\begin{aligned} & \pm 11 \\ & \pm 2.5 \end{aligned}$ | $\begin{aligned} & \pm 12 \\ & \pm 3 \end{aligned}$ |  | $\mathrm{V}$ |
| OUTPUT VOLTAGE SWING <br> Short-Circuit Current <br> Output Current ${ }^{4}$ | $\begin{aligned} & \mathrm{R}_{\text {LOAD }}=2 \mathrm{k} \Omega \\ & \mathrm{R}_{\text {LOAD }}=600 \Omega \\ & \mathrm{R}_{\text {LOAD }}=600 \Omega \end{aligned}$ | $\begin{aligned} & \pm 15 \mathrm{~V} \\ & \pm 15 \mathrm{~V} \\ & \pm 5 \mathrm{~V} \\ & \pm 5 \mathrm{~V}, \pm 15 \mathrm{~V} \\ & \pm 5 \mathrm{~V}, \pm 15 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & \pm 12 \\ & \pm 11 \\ & \pm 2.5 \\ & 30 \end{aligned}$ | $\begin{aligned} & \pm 13 \\ & \pm 13 \\ & \pm 3 \\ & 80 \\ & 50 \end{aligned}$ |  | $\begin{aligned} & \pm 12 \\ & \pm 11 \\ & \pm 2.5 \\ & \\ & 30 \end{aligned}$ | $\begin{aligned} & \pm 13 \\ & \pm 13 \\ & \pm 3 \\ & 80 \\ & 50 \end{aligned}$ |  | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~mA} \\ & \mathrm{~mA} \end{aligned}$ |
| TOTAL HARMONIC DISTORTION | $\begin{aligned} & \mathrm{R}_{\text {LOAD }}=1 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{N}}=50 \mathrm{pF} \\ & \mathrm{f}=250 \mathrm{kHz}, 3 \mathrm{Vrms} \\ & \mathrm{R}_{\text {LOAD }}=1 \mathrm{k} \Omega \\ & \mathrm{f}=20 \mathrm{kHz}, 3 \mathrm{~V} \mathrm{rms} \end{aligned}$ | $\begin{aligned} & \pm 15 \mathrm{~V} \\ & \pm 15 \mathrm{~V} \end{aligned}$ |  | $\begin{aligned} & -98 \\ & -120 \end{aligned}$ | $\begin{aligned} & -90 \\ & -110 \end{aligned}$ |  |  | $\begin{aligned} & -90 \\ & -110 \end{aligned}$ | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \end{aligned}$ |
| INPUT CHARACTERISTICS <br> Input Resistance (Differential) Input Resistance (Common Mode) Input Capacitance (Differential) ${ }^{5}$ Input Capacitance (Common Mode) |  |  |  | $\begin{aligned} & 7.5 \\ & 100 \\ & 20 \\ & 5 \end{aligned}$ |  |  | $\begin{aligned} & 7.5 \\ & 100 \\ & 20 \\ & 5 \end{aligned}$ |  | $\begin{aligned} & \mathrm{k} \Omega \\ & \mathrm{M} \Omega \\ & \mathrm{pF} \\ & \mathrm{pF} \end{aligned}$ |
| OUTPUT RESISTANCE | $\mathrm{A}_{\mathrm{v}}=+1, \mathrm{f}=1 \mathrm{kHz}$ |  |  | 3 |  |  | 3 |  | $\mathrm{m} \Omega$ |
| POWER SUPPLY Operating Range Quiescent Current |  | $\pm 5 \mathrm{~V}, \pm 15 \mathrm{~V}$ | $\pm 5$ | $8.2$ | $\begin{aligned} & \pm 18 \\ & 10.5 \end{aligned}$ | $\pm 5$ |  | $\begin{aligned} & \pm 18 \\ & 10.5 \end{aligned}$ | $\left\lvert\, \begin{aligned} & \mathrm{V} \\ & \mathrm{~mA} \end{aligned}\right.$ |

## NOTES

${ }^{1}$ See standard military drawing for 883 B specifications.
${ }^{2}$ Specified using external decompensation capacitor, see applications section.
${ }^{3}$ Full Power Bandwidth $=$ Slew Rate $/ 2 \pi \mathrm{~V}_{\text {PEAK }}$.
${ }^{4}$ Output Current for $\left|\mathrm{V}_{\mathrm{S}}-\mathrm{V}_{\mathrm{OUT}}\right|>4 \mathrm{~V}, \mathrm{~A}_{\mathrm{OL}}>200 \mathrm{k} \Omega$.
${ }^{5}$ Differential input capacitance consists of 1.5 pF package capacitance and 18.5 pF from the input differential pair.
Specifications subject to change without notice.

ABSOLUTE MAXIMUM RATINGS ${ }^{1}$


## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ Internal Power Dissipation:
8 -Pin SOIC $=0.9$ Watts $-\left(\mathrm{T}_{\mathrm{A}}-25^{\circ} \mathrm{C}\right) / \theta_{\mathrm{JA}}$
8 -Pin Plastic DIP and Cerdip $=1.3$ Watts $-\left(\mathrm{T}_{\mathrm{A}}-25^{\circ} \mathrm{C}\right) / \theta_{\text {JA }}$
Thermal Characteristics
8-Pin Plastic DIP Package: $\theta_{\mathrm{JA}}=95^{\circ} \mathrm{C} / \mathrm{W}$
8 -Pin Cerdip Package: $\theta_{\mathrm{JA}}=110^{\circ} \mathrm{C} / \mathrm{W}$
8-Pin Small Outline Package: $\theta_{\mathrm{JA}}=155^{\circ} \mathrm{C} / \mathrm{W}$
${ }^{3}$ The AD797's inputs are protected by back-to-back diodes. To achieve low noise, internal current limiting resistors are not incorporated into the design of this amplifier. If the differential input voltage exceeds $\pm 0.7 \mathrm{~V}$, the input current should be limited to less than 25 mA by series protection resistors. Note, however, that this will degrade the low noise performance of the device.

## ESD SUSCEPTIBILITY

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 volts, which readily accumulate on the human body and on test equipment, can discharge without detection. Although the AD797 features proprietary ESD protection circuitry, permanent damage may still occur on these devices if they are subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid any performance degradation or loss of functionality.

ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD797AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | $\mathrm{N}-8$ |
| AD797BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | $\mathrm{N}-8$ |
| AD797BR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | $\mathrm{R}-8$ |
| AD797AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | $\mathrm{R}-8$ |
| 5962-9313301MPA | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Cerdip | $\mathrm{Q}-8$ |
| AD797A Chips | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Die |  |

$\star$ For outline information see Package Information section.

METALIZATION PHOTO
Contact factory for latest dimensions.
Dimensions shown in inches and (mm)


NOTE
The AD797 has double layer metal. Only one layer is shown here for clarity.


Figure 1. Common-Mode Voltage Range vs. Supply


Figure 2. Output Voltage Swing vs. Supply


Figure 3. Output Voltage Swing vs. Load Resistance


Figure 4. 0.1 Hz to 10 Hz Noise


Figure 5. Input Bias Current vs. Temperature


Figure 6. Short Circuit Current vs. Temperature

## AD797-Typical Characteristics



Figure 7. Quiescent Supply Current vs. Supply Voltage


Figure 8. Output Voltage vs. Supply for 0.01\% Distortion


Figure 9. Settling Time vs. Step Size ( $\pm$ )


Figure 10. Power Supply and Common-Mode Rejection vs. Frequency


Figure 11. Total Harmonic Distortion (THD) + Noise vs. Output Level


Figure 12. Large Signal Frequency Response


Figure 13. Input Voltage Noise Spectral Density


Figure 14. Open-Loop Gain \& Phase vs. Frequency


Figure 15. Input Offset Current vs. Temperature


Figure 16. Slew Rate \& Gain/Bandwidth Product vs. Temperature


Figure 17. Open-Loop Gain vs. Resistive Load


Figure 18. Magnitude of Output Impedance vs. Frequency

## AD797-Typical Characteristics



* SEE FIGURE 32

Figure 19. Inverter
Connection


* VAlue of source resistance SEE TEXT
* SEE FIGURE 32

Figure 22. Follower Connection

See Figure 40 for settling time test circuit.


Figure 20. Inverter Large Signal Pulse Response


Figure 23. Follower Large Signal Pulse Response

Figure 25. 16-Bit Settling Time Positive Input Pulse



Figure 21. Inverter Small Signal Pulse Response


Figure 24. Follower Small Signal Pulse Response


Figure 26. 16-Bit Settling Time Negative Input Pulse

## THEORY OF OPERATION

The new architecture of the AD797 was developed to overcome inherent limitations in previous amplifier designs. Previous precision amplifiers used three stages to ensure high open-loop gain, Figure 27b, at the expense of additional frequency compensation components. Slew rate and settling performance are usually compromised, and dynamic performance is not adequate beyond audio frequencies. As can be seen in Figure 27b, the first stage gain is rolled off at high frequencies by the compensation network. Second stage noise and distortion will then appear at the input and degrade performance. The AD797 on the other hand, uses a single ultrahigh gain stage to achieve dc as well as dynamic precision. As shown in the simplified schematic (Figure 28), nodes A, B, and C all track in voltage forcing the operating points of all pairs of devices in the signal path to match. By exploiting the inherent matching of devices fabricated on the same IC chip, high open-loop gain, CMRR, PSRR, and low $\mathrm{V}_{\mathrm{Os}}$ are all guaranteed by pairwise device matching (i.e., NPN to NPN \& PNP to PNP), and not absolute parameters such as beta and early voltage.

a.

b.

Figure 27. Model of AD797 vs. That of a Typical Three-Stage Amplifier


Figure 28. AD797 Simplified Schematic

This matching benefits not just dc precision but since it holds up dynamically, both distortion and settling time are also reduced. This single stage has a voltage gain of $>5 \times 10^{6}$ and $\mathrm{V}_{\text {os }}<80 \mu \mathrm{~V}$, while at the same time providing THD + noise of less than -120 dB and true 16 bit settling in less than 800 ns . The elimination of second stage noise effects has the additional benefit of making the low noise of the AD797 ( $<0.9 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ ) extend to beyond 1 MHz . This means new levels of performance for sampled data and imaging systems. All of this performance as well as load drive in excess of 30 mA are made possible by Analog Devices' advanced Complementary Bipolar (CB) process.
Another unique feature of this circuit is that the addition of a single capacitor, $\mathrm{C}_{\mathrm{N}}$ (Figure 28), enables cancellation of distortion due to the output stage. This can best be explained by referring to a simplified representation of the AD797 using idealized blocks for the different circuit elements (Figure 29).
A single equation yields the open-loop transfer function of this amplifier, solving it (at Node B) yields:

$$
\frac{V_{O}}{V_{I N}}=\frac{g m}{\frac{C_{N}}{A} j \omega-C_{N} j \omega-\frac{C_{C}}{A} j \omega}
$$

$\mathrm{gm}=$ the transconductance of Q1 and Q2
$\mathrm{A}=$ the gain of the output stage, $(\sim 1)$
$\mathrm{V}_{\mathrm{O}}=$ voltage at the output
$\mathrm{V}_{\mathrm{IN}}=$ differential input voltage
When $C_{N}$ is equal to $C_{C}$ this gives the ideal single pole op amp response:

$$
\frac{V_{O}}{V_{I N}}=\frac{g m}{j \omega C}
$$

The terms in A, which include the properties of the output stage such as output impedance and distortion, cancel by simple subtraction, and therefore the distortion cancellation does not affect the stability or frequency response of the amplifier. With only $500 \mu \mathrm{~A}$ of output stage bias the AD797 delivers a 1 kHz sine wave into $600 \Omega$ at 7 V rms with only 1 ppm of distortion.


Figure 29. AD797 Block Diagram

## NOISE AND SOURCE IMPEDANCE CONSIDERATIONS

The AD797's ultralow voltage noise of $0.9 \mathrm{nV} \sqrt{\mathrm{Hz}}$ is achieved with special input transistors running at nearly 1 mA of collector current. It is important then to consider the total input referred noise ( $\mathrm{e}_{\mathrm{N}}$ total), which includes contributions from voltage noise ( $\mathrm{e}_{\mathrm{N}}$ ), current noise ( $\mathrm{i}_{\mathrm{N}}$ ), and resistor noise ( $\sqrt{4 \mathrm{kTr}}{ }_{\mathrm{S}}$ ).

$$
e_{N} \text { total }=\left[e_{N}^{2}+4 k T r_{S}+4\left(i_{N} r_{S}\right)^{2}\right]^{1 / 2} \quad \text { Equation } 1
$$

where $r_{s}=$ total input source resistance.
This equation is plotted for the AD797 in Figure 30. Since optimum dc performance is obtained with matched source resistances, this case is considered even though it is clear from Equation 1 that eliminating the balancing source resistance will lower the total noise by reducing the total $r_{S}$ by a factor of two.
At very low source resistance ( $\mathrm{r}_{\mathrm{s}}<50 \Omega$ ), the amplifiers' voltage noise dominates. As source resistance increases the Johnson noise of $r_{S}$ dominates until at higher resistances ( $r_{S}>2 \mathrm{k} \Omega$ ) the current noise component is larger than the resistor noise.


Figure 30. Noise vs. Source Resistance
The AD797 is the optimum choice for low noise performance provided the source resistance is kept $<1 \mathrm{k} \Omega$. At higher values of source resistance, optimum performance with respect to noise alone is obtained with other amplifiers from Analog Devices (see Table I).

Table I. Recommended Amplifiers for Different Source Impedances

| $\mathbf{r}_{\mathbf{s}}$, ohms | Recommended Amplifier |
| :--- | :--- |
| 0 to $<1 \mathrm{k}$ | AD797 |
| 1 k to $<10 \mathrm{k}$ | AD707, AD743/AD745, OP-27/OP-37, OP-07 |
| 10 k to $<100 \mathrm{k}$ | AD705, AD743/AD745, OP-07 |
| $>100 \mathrm{k}$ | AD548, AD549, AD645, AD711, |
|  | AD743/AD745 |

## LOW FREQUENCY NOISE

Analog Devices specifies low frequency noise as a peak to peak (p-p) quantity in a 0.1 Hz to 10 Hz bandwidth. Several techniques can be used to make this measurement. The usual technique involves amplifying, filtering, and measuring the amplifiers noise for a predetermined test time. The noise bandwidth of the filter is corrected for and the test time is carefully controlled since the measurement time acts as an additional low frequency roll-off.
The plot in Figure 4 was made using a slightly different technique. Here an FFT based instrument (Figure 31) is used to generate a 10 Hz "brickwall" filter. A low frequency pole at 0.1 Hz is generated with an external ac coupling capacitor, the instrument being dc coupled.
Several precautions are necessary to get optimum low frequency noise performance:

1. Care must be used to account for the effects of $r_{s}$, even a $10 \Omega$ resistor has $0.4 \mathrm{nV} \sqrt{\mathrm{Hz}}$ of noise (an error of $9 \%$ when root sum squared with $0.9 \mathrm{nV} \sqrt{\mathrm{Hz}}$.
2. The test set up must be fully warmed up to prevent $e_{o s}$ drift from erroneously contributing to input noise.
3. Circuitry must be shielded from air currents. Heat flow out of the package through its leads creates the opportunity for a thermo-electric potential at every junction of different metals. Selective heating and cooling of these by random air currents will appear as $1 / \mathrm{f}$ noise and obscure the true device noise.
4. The results must be interpreted using valid statistical techniques.

** USE POWER SUPPLY BYPASSING SHOWN IN FIGURE 32.
Figure 31. Test Setup for Measuring 0.1 Hz to 10 Hz Noise

## WIDEBAND NOISE

The AD797, due to its single stage design, has the property that its noise is flat over frequencies from less than 10 Hz to beyond 1 MHz . This is not true of most dc precision amplifiers where second stage noise contributes to input referred noise beyond the audio frequency range. The AD797 offers new levels of performance in wideband imaging applications. In sampled data systems, where aliasing of out of band noise into the signal band is a problem, the AD797 will out perform all previously available IC op amps.

## BYPASSING CONSIDERATIONS

To take full advantage of the very wide bandwidth and dynamic range capabilities of the AD797 requires some precautions. First, multiple bypassing is recommended in any precision application. A $1.0 \mu \mathrm{~F}-4.7 \mu \mathrm{~F}$ tantalum in parallel with $0.1 \mu \mathrm{~F}$ ceramic bypass capacitors are sufficient in most applications. When driving heavy loads a larger demand is placed on the supply bypassing. In this case selective use of larger values of tantalum capacitors and damping of their lead inductance with small value ( $1.1 \Omega$ to $4.7 \Omega$ ) carbon resistors can be an improvement. Figure 32 summarizes bypassing recommendations. The symbol $(\star \star)$ is used throughout this data sheet to represent the parallel combination of a $0.1 \mu \mathrm{~F}$ and a $4.7 \mu \mathrm{~F}$ capacitor.


Figure 32. Recommended Power Supply Bypassing

## THE NONINVERTING CONFIGURATION

Ultralow noise requires very low values of $\mathrm{r}_{\mathrm{BB}}$ ' (the internal parasitic resistance) for the input transistors ( $\approx 6 \Omega$ ). This implies very little damping of input and output reactive interactions. With the AD797, additional input series damping is required for stability with direct input to output feedback. A $100 \Omega$ resistor in the inverting input (Figure 33) is sufficient; the $100 \Omega$ balancing resistor (R2) is recommended, but is not required for stability. The noise penalty is minimal ( $\mathrm{e}_{\mathrm{N}}$ total $\approx 2.1 \mathrm{nV} \sqrt{\mathrm{Hz}}$ ), which is usually insignificant. Best response flatness is obtained with the addition of a small capacitor ( $\mathrm{C}_{\mathrm{L}}<33 \mathrm{pF}$ ) in parallel with the $100 \Omega$ resistor (Figure 34). The input source resistance and capacitance will also affect the response slightly and experimentation may be necessary for best results.

** USE POWER SUPPLY BYPASSING SHOWN IN FIGURE 32.
Figure 33. Voltage Follower Connection
Low noise preamplification is usually done in the noninverting mode (Figure 35). For lowest noise the equivalent resistance of the feedback network should be as low as possible. The 30 mA minimum drive current of the AD797 makes it easier to achieve this. The feedback resistors can be made as low as possible with due consideration to load drive and power consumption. Table II gives some representative values for the AD797 as a low noise follower. Operation on 5 volt supplies allows the use of a $100 \Omega$
or less feedback network ( $\mathrm{R} 1+\mathrm{R} 2$ ). Since the AD797 shows no unusual behavior when operating near its maximum rated current, it is suitable for driving the AD600/AD602 (Figure 47) while preserving their low noise performance.
Optimum flatness and stability at noise gains $>1$ sometimes requires a small capacitor ( $\mathrm{C}_{\mathrm{L}}$ ) connected across the feedback resistor (R1, Figure 35). Table II includes recommended values of $C_{L}$ for several gains. In general, when $R 2$ is greater than $100 \Omega$ and $\mathrm{C}_{\mathrm{L}}$ is greater than 33 pF , a $100 \Omega$ resistor should be placed in series with $\mathrm{C}_{\mathrm{L}}$. Source resistance matching is assumed, and the AD797 should never be operated with unbalanced source resistance $>200 \mathrm{k} \Omega / \mathrm{G}$.


* SEE TEXT
** USE POWER SUPPLY BYPASSING SHOWN IN FIGURE 32.
Figure 34. Alternative Voltage Follower Connection

** USE POWER SUPPLY BYPASSING SHOWN IN FIGURE 32.
Figure 35. Low Noise Preamplifier
Table II. Values for Follower with Gain Circuit

| Gain | $\mathbf{R 1}$ | $\mathbf{R 2}$ | $\mathbf{C}_{\mathbf{L}}$ | Noise <br> (Excluding $\left.\mathbf{r}_{\mathbf{s}}\right)$ |
| :--- | :--- | :--- | :--- | :--- |
| 2 | $1 \mathrm{k} \Omega$ | $1 \mathrm{k} \Omega$ | $\approx 20 \mathrm{pF}$ | $3.0 \mathrm{nV} \sqrt{\mathrm{Hz}}$ |
| 2 | $300 \Omega$ | $300 \Omega$ | $\approx 10 \mathrm{pF}$ | $1.8 \mathrm{nV} \sqrt{\mathrm{Hz}}$ |
| 10 | $33.2 \Omega$ | $300 \Omega$ | $\approx 5 \mathrm{pF}$ | $1.2 \mathrm{nV} \sqrt{\mathrm{Hz}}$ |
| 20 | $16.5 \Omega$ | $316 \Omega$ |  | $1.0 \mathrm{nV} \sqrt{\mathrm{Hz}}$ |
| $>35$ | $10 \Omega$ | $(\mathrm{G}-1)$ | $10 \Omega$ |  |

The I-to-V converter is a special case of the follower configuration. When the AD797 is used in an I-to-V converter, for instance as a DAC buffer, the circuit of Figure 36 should be used. The value of $C_{L}$ depends on the DAC and again, if $C_{L}$ is


* SEE TEXT
* USE POWER SUPPLY BYPASSING SHOWN IN FIGURE 32.

Figure 36. I-to-V Converter Connection
greater than 33 pF a $100 \Omega$ series resistor is required. A by-passed balancing resistor ( $\mathrm{R}_{\mathrm{S}}$ and $\mathrm{C}_{\mathrm{S}}$ ) can be included to minimize dc errors.

## THE INVERTING CONFIGURATION

The inverting configuration (Figure 37) presents a low input impedance, R1, to the source. For this reason, the goals of both low noise and input buffering are at odds with one another. Nonetheless, the excellent dynamics of the AD797 will make it the preferred choice in many inverting applications, and with careful selection of feedback resistors the noise penalties will be minimal. Some examples are presented in Table II and Figure 37.


* SEE TEXT
** USE POWER SUPPLY BYPASSING SHOWN IN FIGURE 32.
Figure 37. Inverting Amplifier Connection
Table III. Values for Inverting Circuit

| Gain | $\mathbf{R 1}$ | $\mathbf{R 2}$ | $\mathbf{C}_{\mathbf{L}}$ | Noise <br> (Excluding $\left.\mathrm{r}_{\mathbf{s}}\right)$ |
| :--- | :--- | :--- | :--- | :--- |
| -1 | $1 \mathrm{k} \Omega$ | $1 \mathrm{k} \Omega$ | $\approx 20 \mathrm{pF}$ | $3.0 \mathrm{nV} \sqrt{\mathrm{Hz}}$ |
| -1 | $300 \Omega$ | $300 \Omega$ | $\approx 10 \mathrm{pF}$ | $1.8 \mathrm{nV} \sqrt{\mathrm{Hz}}$ |
| -10 | $150 \Omega$ | $1500 \Omega$ | $\approx 5 \mathrm{pF}$ | $1.8 \mathrm{nV} \sqrt{\mathrm{Hz}}$ |

## DRIVING CAPACITIVE LOADS

The capacitive load driving capabilities of the AD797 are displayed in Figure 38. At gains over 10 usually no special precautions are necessary. If more drive is desirable the circuit in Figure 39 should be used. Here a 5000 pF load can be driven cleanly at any noise gain $>=2$.


Figure 38. Capacitive Load Drive Capability vs. Closed-Loop Gain


Figure 39. Recommended Circuit for Driving a High Capacitance Load

## SETTLING TIME

The AD797 is unique among ultralow noise amplifiers in that it settles to 16 bits $(<150 \mu \mathrm{~V})$ in less than 800 ns . Measuring this performance presents a challenge. A special test setup (Figure 40) was developed for this purpose. The input signal was obtained from a resonant reed switch pulse generator, available from Tektronix as calibration Fixture No. 067-0608-00. When open, the switch is simply $50 \Omega$ to ground and settling is purely a passive pulse decay and inherently flat. The low repetition rate signal was captured on a digital oscilloscope after being amplified and clamped twice. The selection of plug-in for the oscilloscope was made for minimum overload recovery.


Figure 40. Settling Time Test Circuit

## DISTORTION REDUCTION

The AD797 has distortion performance (THD <-120 dB, @ $20 \mathrm{kHz}, 3 \mathrm{~V} \mathrm{rms}, \mathrm{RL}=600 \Omega$ ) unequaled by most voltage feedback amplifiers.
At higher gains and higher frequencies THD will increase due to reduction in loop gain. However in contrast to most conventional voltage feedback amplifiers the AD797 provides two effective means of reducing distortion, as gain and frequency are increased; cancellation of the output stage's distortion and gain bandwidth enhancement by decompensation. By applying these techniques gain bandwidth can be increased to 450 MHz at $\mathrm{G}=1000$ and distortion can be held to -100 dB at 20 kHz for $\mathrm{G}=100$.

The unique design of the AD797 provides for cancellation of the output stage's distortion (patent pending). To achieve this a capacitance equal to the effective compensation capacitance, usually 50 pF , is connected between Pin 8 and the output ( C 2 in Figure 41 ). Use of this feature will improve distortion performance when the closed loop gain is more than 10 or when frequencies of interest are greater than 30 kHz .
Bandwidth enhancement via decompensation is achieved by connecting a capacitor from Pin 8 to ground ( Cl in Figure 41) effectively subtracting from the value of the internal compensation capacitance ( 50 pF ), yielding a smaller effective compensation capacitance and, therefore, a larger bandwidth. The benefits of this begin at closed loop gains of 100 and up. A maximum value of $\approx 33 \mathrm{pF}$ at gains of 1000 and up is recommended. At a gain of 1000 the bandwidth is 450 kHz .
Table IV and Figure 42 summarize the performance of the AD797 with distortion cancellation and decompensation.

b.

Figure 41. Recommended Connections for Distortion Cancellation and Bandwidth Enhancement

Table IV. Recommended External Compensation

|  | $\mathbf{A} / \mathbf{B}$ |  | $\mathbf{A}$ |  |  | $\mathbf{B}$ |  |  |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
|  | $\mathbf{R 1}$ | $\mathbf{R 2}$ | $\mathbf{C 1}$ | $\mathbf{C 2}$ | $\mathbf{3} \mathbf{~ d B}$ | $\mathbf{C 1}$ | $\mathbf{C 2}$ | $\mathbf{3} \mathbf{~ d B}$ |
|  | $\boldsymbol{\Omega}$ | $\boldsymbol{\Omega}$ | $(\mathbf{p F})$ | $\mathbf{B W}$ | $(\mathbf{p F})$ | $\mathbf{B W}$ |  |  |
| $\mathrm{G}=10$ | 909 | 100 | 0 | 50 | 6 MHz | 0 | 50 | 6 MHz |
| $\mathrm{G}=100$ | 1 k | 10 | 0 | 50 | 1 MHz | 15 | 33 | 1.5 MHz |
| $\mathrm{G}=1000$ | 10 k | 10 | 0 | 50 | 110 kHz | 33 | 15 | 450 kHz |



Figure 42. Total Harmonic Distortion (THD) vs. Frequency @ 3 V rms for Figure 41b

## Differential Line Receiver

The differential receiver circuit of Figure 43 is useful for many applications from audio to MRI imaging. It allows extraction of a low level signal in the presence of common-mode noise. As shown in Figure 44, the AD797 provides this function with only $9 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ noise at the output. Figure 45 shows the AD797's 20-bit THD performance over the audio band and 16-bit accuracy to 250 kHz .


Figure 43. Differential Line Receiver


Figure 44. Output Voltage Noise Spectral Density for Differential Line Receiver

A General Purpose ATE/Instrumentation Input/Output Driver The ultralow noise and distortion of the AD797 may be combined with the wide bandwidth, slew rate, and load drive of a current feedback amplifier to yield a very wide dynamic range general purpose driver. The circuit of Figure 46 combines the AD797 with the AD811 in just such an application. Using the


Figure 45. Total Harmonic Distortion (THD) vs. Frequency for Differential Line Receiver
component values shown, this circuit is capable of better than -90 dB THD with a $\pm 5 \mathrm{~V}, 500 \mathrm{kHz}$ output signal. The circuit is therefore suitable for driving high resolution $\mathrm{A} / \mathrm{D}$ converters and as an output driver in automatic test equipment (ATE) systems. Using a 100 kHz sine wave, the circuit will drive a $600 \Omega$ load to a level of 7 V rms with less than -109 dB THD, and a $10 \mathrm{k} \Omega$ load at less than -117 dB THD.


Figure 46. A General Purpose ATE/Instrumentation Input/Output Driver

## Ultrasound/Sonar Imaging Preamp

The AD600 variable gain amplifier provides the time controlled gain (TCG) function necessary for very wide dynamic range sonar and low frequency ultrasound applications. Under some circumstances, it is necessary to buffer the input of the AD600 to preserve its low noise performance. To optimize dynamic range this buffer should have at most 6 dB of gain. The combination of low noise and low gain is difficult to achieve. The input buffer circuit shown in Figure 47 provides $1 \mathrm{nV} \sqrt{\mathrm{Hz}}$ noise performance at a gain of two (dc to 1 MHz ) by using $26.1 \Omega$ resistors in its feedback path. Distortion is only -50 dBc @ 1 MHz at a 2 volt p-p output level and drops rapidly to better than -70 dBc at an output level of $200 \mathrm{mV} \mathrm{p}-\mathrm{p}$.


Figure 47. An Ultrasound Preamplifier Circuit

## Amorphous (Photodiode) Detector

Large area photodiodes $\mathrm{C}_{\mathrm{S}} \geq 500 \mathrm{pF}$ and certain image detectors (amorphous Si ), have optimum performance when used in conjunction with amplifiers with very low voltage rather than very low current noise. Figure 48 shows the AD797 used with an amorphous $\mathrm{Si}\left(\mathrm{C}_{\mathrm{S}}=1000 \mathrm{pF}\right)$ detector. The response is adjusted for flatness using capacitor $\mathrm{C}_{\mathrm{L}}$, while the noise is dominated by voltage noise amplified by the ac noise gain. The 797's excellent input noise performance gives $27 \mu \mathrm{~V}$ rms total noise in a 1 MHz bandwidth, as shown by Figure 49.

** USE POWER SUPPLY BYPASSING SHOWN IN FIGURE 32.
Figure 48. Amorphous Detector Preamp


Figure 49. Total Integrated Voltage Noise \& $V_{\text {OUT }}$ of Amorphous Detector Preamp

## Professional Audio Signal Processing-DAC Buffers

The low noise and low distortion of the AD797 make it an ideal choice for professional audio signal processing. An ideal I-to-V converter for a current output DAC would simply be a resistor to ground, were it not for the fact that most DACs do not operate linearly with voltage on their output. Standard practice is to operate an op amp as an I-to-V converter creating a virtual ground at its inverting input. Normally, clock energy and current steps must be absorbed by the op amp's output stage. However, in the configuration of Figure 50, Capacitor $C_{F}$ shunts high frequency energy to ground, while correctly reproducing the desired output with extremely low THD and IMD.

** USE POWER SUPPLY BYPASSING SHOWN IN FIGURE 32.
Figure 50. A Professional Audio DAC Buffer


Figure 51. Offset Null Configuration

## FEATURES <br> High Speed

80 MHz Bandwidth ( $3 \mathrm{~dB}, \mathrm{G}=+1$ )
75 MHz Bandwidth ( $3 \mathrm{~dB}, \mathrm{G}=+2$ )
1000 V/ $\mu \mathrm{s}$ Slew Rate
50 ns Settling Time to $\mathbf{0 . 1 \%}$ ( $\mathrm{V}_{\mathrm{o}}=10 \mathrm{~V}$ Step)
Ideal for Video Applications
30 MHz Bandwidth ( $\mathbf{0 . 1} \mathrm{dB}, \mathbf{G}=+2$ )
0.02\% Differential Gain
$0.04^{\circ}$ Differential Phase
Low Noise
$2.9 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ Input Voltage Noise
$13 \mathrm{pA} / \sqrt{\mathrm{Hz}}$ Inverting Input Current Noise
Low Power
8.0 mA Supply Current max
2.1 mA Supply Current (Power-Down Mode)

High Performance Disable Function
Turn-Off Time 100 ns
Break Before Make Guaranteed Input to Output Isolation of 64 dB (OFF State)
Flexible Operation
Specified for $\pm 5$ V and $\pm 15 \mathrm{~V}$ Operation
$\pm 2.9$ V Output Swing Into a $150 \Omega$ Load ( $\mathrm{V}_{\mathrm{s}}= \pm 5 \mathrm{~V}$ )

## APPLICATIONS

Professional Video Cameras
Multimedia Systems
NTSC, PAL \& SECAM Compatible Systems
Video Line Driver
ADC/DAC Buffer
DC Restoration Circuits

CONNECTION DIAGRAM
8-Pin Plastic Mini-DIP (N), SOIC (R) and Cerdip (Q) Packages


## PRODUCT DESCRIPTION

The AD810 is a composite and HDTV compatible, current feedback, video operational amplifier, ideal for use in systems such as multimedia, digital tape recorders and video cameras. The 0.1 dB flatness specification at bandwidth of 30 MHz ( $\mathrm{G}=+2$ ) and the differential gain and phase of $0.02 \%$ and $0.04^{\circ}$ (NTSC) make the AD810 ideal for any broadcast quality video system. All these specifications are under load conditions of $150 \Omega$ (one $75 \Omega$ back terminated cable).
The AD810 is ideal for power sensitive applications such as video cameras, offering a low power supply current of 8.0 mA max. The disable feature reduces the power supply current to only 2.1 mA , while the amplifier is not in use, to conserve power. Furthermore the AD810 is specified over a power supply range of $\pm 5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$.
The AD810 works well as an ADC or DAC buffer in video systems due to its unity gain bandwidth of 80 MHz . Because the AD810 is a transimpedance amplifier, this bandwidth can be maintained over a wide range of gains while featuring a low noise of $2.9 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ for wide dynamic range applications.


Differential Gain and Phase vs. Supply Voltage

| Parameter | Conditions | $\mathbf{v}_{\text {s }}$ | AD810A |  |  | AD810S ${ }^{1}$ |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max | Min | Typ | Max |  |
| DYNAMIC PERFORMANCE |  |  |  |  |  |  |  |  |  |
| 3 dB Bandwidth | $(\mathrm{G}=+2) \mathrm{R}_{\mathrm{FB}}=715$ | $\pm 5 \mathrm{~V}$ | 40 | 50 |  | 40 | 50 |  | MHz |
|  | $(\mathrm{G}=+2) \mathrm{R}_{\mathrm{FB}}=715$ | $\pm 15 \mathrm{~V}$ | 55 | 75 |  | 55 | 75 |  | MHz |
|  | $(\mathrm{G}=+1) \mathrm{R}_{\mathrm{FB}}=1000$ | $\pm 15 \mathrm{~V}$ | 40 | 80 |  | 40 | 80 |  | MHz |
|  | $(\mathrm{G}=+10) \mathrm{R}_{\mathrm{FB}}=270$ | $\pm 15 \mathrm{~V}$ | 50 | 65 |  | 50 | 65 |  | MHz |
| 0.1 dB Bandwidth | $(\mathrm{G}=+2) \mathrm{R}_{\mathrm{FB}}=715$ | $\pm 5 \mathrm{~V}$ | 13 | 22 |  | 13 | 22 |  | MHz |
|  | $(\mathrm{G}=+2) \mathrm{R}_{\mathrm{FB}}=715$ | $\pm 15 \mathrm{~V}$ | 15 | 30 |  | 15 | 30 |  | MHz |
| Full Power Bandwidth | $\mathrm{V}_{\mathrm{O}}=20 \mathrm{~V} \mathrm{p}$ - , |  |  |  |  |  |  |  |  |
|  | $\mathrm{R}_{\mathrm{L}}=400 \Omega$ | $\pm 15 \mathrm{~V}$ |  | 16 |  |  | 16 |  | MHz |
| Slew Rate ${ }^{2}$ | $\mathrm{R}_{\mathrm{L}}=150 \Omega$ | $\pm 5 \mathrm{~V}$ |  | 350 |  |  | 350 |  | V/us |
|  | $\mathrm{R}_{\mathrm{L}}=400 \Omega$ | $\pm 15 \mathrm{~V}$ |  | 1000 |  |  | 1000 |  | $\mathrm{V} / \mathrm{\mu s}$ |
| Settling Time to 0.1\% | 10 V Step, $\mathrm{G}=-1$ | $\pm 15 \mathrm{~V}$ |  | 50 |  |  | 50 |  |  |
| Settling Time to 0.01\% | 10 V Step, $\mathrm{G}=-1$ | $\pm 15 \mathrm{~V}$ |  | 125 |  |  | 125 |  |  |
| Differential Gain | $\mathrm{f}=3.58 \mathrm{MHz}$ | $\pm 15 \mathrm{~V}$ |  | 0.02 | 0.05 |  | 0.02 | 0.05 | \% |
|  | $\mathrm{f}=3.58 \mathrm{MHz}$ | $\pm 5 \mathrm{~V}$ |  | 0.04 | 0.07 |  | 0.04 | 0.07 |  |
| Differential Phase | $\mathrm{f}=3.58 \mathrm{MHz}$ | $\pm 15 \mathrm{~V}$ |  | 0.04 | 0.07 |  | 0.04 | 0.07 | Degrees |
|  | $\mathrm{f}=3.58 \mathrm{MHz}$ | $\pm 5 \mathrm{~V}$ |  | 0.045 | 0.08 |  | 0.045 | 0.08 | Degrees |
| Total Harmonic Distortion | $\begin{aligned} & f=10 \mathrm{MHz}, \mathrm{~V}_{\mathrm{O}}=2 \mathrm{Vp}-\mathrm{p} \\ & \mathrm{R}_{\mathrm{L}}=400 \Omega, \mathrm{G}=+2 \end{aligned}$ | $\pm 15 \mathrm{~V}$ |  | -61 |  |  | -61 |  | dBc |
| INPUT OFFSET VOLTAGE | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ | $\pm 5 \mathrm{~V}, \pm 15 \mathrm{~V}$ |  | 1.5 | 6 |  | 1.5 | 6 | mV |
|  |  | $\pm 5 \mathrm{~V}, \pm 15 \mathrm{~V}$ |  | 2 | 7.5 |  | 4 | 15 | mV |
| Offset Voltage Drift |  |  |  | 7 |  |  | 15 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| INPUT BIAS CURRENT <br> -Input <br> + Input |  |  |  |  |  |  |  |  |  |
|  | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ | $\pm 5 \mathrm{~V}, \pm 15 \mathrm{~V}$ |  | 0.7 | 5 |  | 0.8 | 5 | $\mu \mathrm{A}$ |
|  | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ | $\pm 5 \mathrm{~V}, \pm 15 \mathrm{~V}$ |  | 2 | 7.5 |  | 2 | 10 | $\mu \mathrm{A}$ |
| OPEN-LOOP TRANSRESISTANCE |  |  |  |  |  |  |  |  |  |
|  | $\mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=400 \Omega$ | $\pm 15 \mathrm{~V}$ | 1.0 | 3.5 |  | 1.0 | 3.5 |  | M $\Omega$ |
|  | $\mathrm{V}_{\mathrm{O}}= \pm 2.5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=100 \Omega$ | $\pm 5 \mathrm{~V}$ | 0.3 | 1.2 |  | 0.2 | 1.0 |  | $\mathrm{M} \Omega$ |
| $\begin{aligned} & \text { OPEN-LOOP } \\ & \text { DC VOLTAGE GAIN } \end{aligned}$ | $\mathrm{T}_{\mathrm{MIN}}-\mathrm{T}_{\mathrm{MAX}}$ |  |  |  |  |  |  |  |  |
|  | $\begin{aligned} & \mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=400 \Omega \\ & \mathrm{~V}_{\mathrm{O}}= \pm 2.5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=100 \Omega \end{aligned}$ | $\begin{aligned} & \pm 5 \mathrm{~V} \\ & \pm 5 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 86 \\ & 76 \end{aligned}$ | $\begin{aligned} & 100 \\ & 88 \end{aligned}$ |  | $\begin{array}{\|l} 80 \\ 72 \\ \hline \end{array}$ | $\begin{aligned} & 100 \\ & 88 \end{aligned}$ |  | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \end{aligned}$ |
| COMMON-MODE REJECTION$\mathrm{v}_{\mathrm{Os}}$ | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ |  |  |  |  |  |  |  |  |
|  | $\mathrm{V}_{\mathrm{CM}}= \pm 12 \mathrm{~V}$ | $\pm 15 \mathrm{~V}$ | 56 | 64 |  | 56 | 64 |  | dB |
|  | $\mathrm{V}_{\mathrm{CM}}= \pm 2.5 \mathrm{~V}$ | $\pm 5 \mathrm{~V}$ | 52 | 60 |  | 50 | 60 |  | dB |
| $\pm$ Input Current | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ | $\pm 5 \mathrm{~V}, \pm 15 \mathrm{~V}$ |  | 0.1 | 0.4 |  | 0.1 | 0.4 | $\mu \mathrm{A} / \mathrm{V}$ |
| ```POWER SUPPLY REJECTION Vos Input Current``` | $\begin{aligned} & \mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }} \\ & \mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }} \end{aligned}$ | $\pm 4.5 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | 65 |  |  |  |  |  |  |
|  |  |  |  | 72 |  | 60 | 72 |  |  |
|  |  |  |  | 0.05 | 0.3 |  | 0.05 | 0.3 | $\mu \mathrm{A} / \mathrm{V}$ |
| INPUT VOLTAGE NOISE | $\mathrm{f}=1 \mathrm{kHz}$ | $\pm 5 \mathrm{~V}, \pm 15 \mathrm{~V}$ |  | 2.9 |  |  | 2.9 |  | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| INPUT CURRENT NOISE | $-\mathrm{I}_{\mathrm{IN}}, \mathrm{f}=1 \mathrm{kHz}$ | $\pm 5 \mathrm{~V}, \pm 15 \mathrm{~V}$ |  | 13 |  |  | 13 |  | $\mathrm{pA} / \sqrt{\underline{\mathrm{Hz}}}$ |
|  | $+\mathrm{I}_{\text {IN }}, \mathrm{f}=1 \mathrm{kHz}$ | $\pm 5 \mathrm{~V}, \pm 15 \mathrm{~V}$ |  | 1.5 |  |  | 1.5 |  | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
| INPUT COMMON-MODE VOLTAGE RANGE |  | $\pm 5 \mathrm{~V}$ | $\pm 2.5$ | $\pm 3.0$ |  | $\pm 2.5$ | $\pm 3$ |  | V |
|  |  | $\pm 15 \mathrm{~V}$ | $\pm 12$ | $\pm 13$ |  | $\pm 12$ | $\pm 13$ |  | V |
| OUTPUT CHARACTERISTICS Output Voltage Swing ${ }^{3}$ | $\begin{aligned} & R_{\mathrm{L}}=150 \Omega, \mathrm{~T}_{\mathrm{MIN}}-\mathrm{T}_{\mathrm{MAX}} \\ & \mathrm{R}_{\mathrm{L}}=400 \Omega \\ & \mathrm{R}_{\mathrm{L}}=400 \Omega, \mathrm{~T}_{\mathrm{MIN}}-\mathrm{T}_{\mathrm{MAX}} \end{aligned}$ |  |  |  |  |  |  |  |  |
|  |  | $\pm 5 \mathrm{~V}$ | $\pm 2.5$ | $\pm 2.9$ |  | $\pm 2.5$ | $\pm 2.9$ |  | V |
|  |  | $\pm 15 \mathrm{~V}$ | $\pm 12.5$ | $\pm 12.9$ |  | $\pm 12.5$ | $\pm 12.9$ |  | V |
|  |  | $\pm 15 \mathrm{~V}$ | $\pm 12$ |  |  | $\pm 12$ |  |  | V |
| Short-Circuit Current |  | $\pm 15 \mathrm{~V}$ |  | 150 |  |  | 150 |  | mA |
| Output Current | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ | $\pm 5 \mathrm{~V}, \pm 15 \mathrm{~V}$ |  | 60 |  |  | 60 |  | mA |
| OUTPUT RESISTANCE | Open Loop ( 5 MHz ) |  |  | 15 |  |  | 15 |  | $\Omega$ |
| INPUT CHARACTERISTICS Input Resistance | +Input <br> - Input <br> +Input |  |  |  |  |  |  |  |  |
|  |  | $\pm 15 \mathrm{~V}$ | 2.5 | 10 |  | 2.5 | 10 |  | $\mathrm{M} \Omega$ |
|  |  | $\pm 15 \mathrm{~V}$ |  | 40 |  |  | 40 |  | $\Omega$ |
| Input Capacitance |  | $\pm 15 \mathrm{~V}$ |  | 2 |  |  | 2 |  | pF |
| DISABLE CHARACTERISTICS ${ }^{4}$ <br> OFF Isolation OFF Output Impedance | $\mathrm{f}=5 \mathrm{MHz}$, See Figure 43 See Figure 43 |  |  |  |  |  |  |  |  |
|  |  |  |  | 64 |  |  | 64 |  | dB |
|  |  |  |  | + $\left.\mathrm{R}_{\mathrm{G}}\right) \mid 113$ |  |  | R $\mathrm{R}_{\text {G }}$ )\|13 |  |  |

AD810


NOTES ${ }^{1}$ See Analog Devices Military Data Sheet for 883B Specifications.
${ }^{2}$ Slew rate measurement is based on $10 \%$ to $90 \%$ rise time with the amplifier configured for a gain of -10 .
${ }^{3}$ Voltage Swing is defined as useful operating range, not the saturation range.
${ }^{4}$ Disable guaranteed break before make.
${ }^{5}$ Turn On Time is defined with $\pm 5 \mathrm{~V}$ supplies using complementary output CMOS to drive the disable pin.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 18$ V Internal Power Dissipation ${ }^{2}$. . . . . . . Observe Derating Curves Output Short Circuit Duration . . . . . Observe Derating Curves Common-Mode Input Voltage . . . . . . . . . . . . . . . . . . . $\pm$ V
Differential Input Voltage . . . . . . . . . . . . . . . . . . . . . $\pm 6$ V
Storage Temperature Range
Plastic DIP . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Cerdip . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Small Outline IC . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$

Small Outline IC . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Operating Temperature Range
AD810A . . . . . . . . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
AD810S . . . . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Lead Temperature Range (Soldering 60 sec ) . . . . . . . $+300^{\circ} \mathrm{C}$

## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2} 8$-Pin Plastic Package: $\theta_{\mathrm{JA}}=90^{\circ} \mathrm{C} /$ Watt; 8-Pin Cerdip Package: $\theta_{\mathrm{JA}}=$ $110^{\circ} \mathrm{C} /$ Watt; 8-Pin SOIC Package: $\theta_{\mathrm{JA}}=150^{\circ} \mathrm{C} /$ Watt.

## ESD SUSCEPTIBILITY

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 volts, which readily accumulate on the human body and on test equipment, can discharge without detection. Although the AD810 features ESD protection circuitry, permanent damage may still occur on these devices if they are subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid any performance degradation or loss of functionality.

ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD810AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | $\mathrm{N}-8$ |
| AD810AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C} \mathrm{C}$ | 8-Pin Plastic SOIC | R-8 |
| AD810AR-REEL | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | $\mathrm{R}-8$ |
| 5962-9313201MPA | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Cerdip | $\mathrm{Q}-8$ |

*For outline information see Package Information section.

## MAXIMUM POWER DISSIPATION

The maximum power that can be safely dissipated by the AD810 is limited by the associated rise in junction temperature. For the plastic packages, the maximum safe junction temperature is $145^{\circ} \mathrm{C}$. For the cerdip package, the maximum junction temperature is $175^{\circ} \mathrm{C}$. If these maximums are exceeded momentarily, proper circuit operation will be restored as soon as the die


## Maximum Power Dissipation vs. Temperature

temperature is reduced. Leaving the device in the "overheated" condition for an extended period can result in device burnout. To ensure proper operation, it is important to observe the derating curves.
While the AD810 is internally short circuit protected, this may not be sufficient to guarantee that the maximum junction temperature is not exceeded under all conditions.


Offset Null Configuration


Figure 1. Input Common-Mode Voltage Range vs. Supply Voltage


Figure 3. Output Voltage Swing vs. Load Resistance


Figure 5. Input Bias Current vs. Temperature


Figure 2. Output Voltage Swing vs. Supply


Figure 4. Supply Current vs. Junction Temperature


Figure 6. Input Offset Voltage vs. Junction Temperature

## AD810-Typical Characteristics



Figure 7. Short Circuit Current vs. Temperature


Figure 9. Closed-Loop Output Resistance vs. Frequency


Figure 11. Large Signal Frequency Response


Figure 8. Linear Output Current vs. Temperature


Figure 10. Output Resistance vs. Frequency, Disabled State


Figure 12. Input Voltage and Current Noise vs. Frequency


Figure 13. Common-Mode Rejection vs. Frequency


Figure 15. Harmonic Distortion vs. Frequency ( $R_{L}=100 \Omega$ )


Figure 17. Output Swing and Error vs. Settling Time


Figure 14. Power Supply Rejection vs. Frequency



Figure 18. Slew Rate vs. Supply Voltage

## AD810 - Typical Characteristics, Noninverting Connection



Figure 19. Noninverting Amplifier Connection


Figure 21. Closed-Loop Gain and Phase vs. Frequency, $G=+1 . R_{F}=1 \mathrm{k} \Omega$ for $\pm 15 \mathrm{~V}, 910 \Omega$ for $\pm 5 \mathrm{~V}$ and $\pm 2.5 \mathrm{~V}$


Figure 23. Bandwidth vs. Supply Voltage, Gain $=+1$, $R_{L}=150 \Omega$


Figure 20. Small Signal Pulse Response, Gain $=+1$, $R_{F}=1 \mathrm{k} \Omega, R_{L}=150 \Omega, V_{S}= \pm 15 \mathrm{~V}$


Figure 22. Closed-Loop Gain and Phase vs. Frequency, $G=+1, R_{F}=1 \mathrm{k} \Omega$ for $\pm 15 \mathrm{~V}, 910 \Omega$ for $\pm 5 \mathrm{~V}$ and $\pm 2.5 \mathrm{~V}$


Figure 24. $-3 d B$ Bandwidth vs. Supply Voltage $G=+1$, $R_{L}=1 \mathrm{k} \Omega$


Figure 25. Small Signal Pulse Response, Gain $=+10$, $R_{F}=442 \Omega, R_{L}=150 \Omega, V_{S}= \pm 15 \mathrm{~V}$


Figure 27. Closed-Loop Gain and Phase vs. Frequency, $G=+10, R_{L}=150 \Omega$


Figure 29. $-3 d B$ Bandwidth vs. Supply Voltage, Gain $=+10, R_{L}=150 \Omega$


Figure 26. Large Signal Pulse Response, Gain $=+10$, $R_{F}=442 \Omega, R_{L}=400 \Omega, V_{S}= \pm 15 \mathrm{~V}$


Figure 28. Closed-Loop Gain and Phase vs. Frequency, $G=+10, R_{L}=1 \mathrm{k} \Omega$


Figure 30. $-3 d B$ Bandwidth vs. Supply Voltage, Gain $=+10, R_{L}=1 k \Omega$

## AD810 - Typical Characteristics, Inverting Connection



Figure 31. Inverting Amplifier Connection


Figure 33. Closed-Loop Gain and Phase vs. Frequency, $G=-1, R_{L}=150 \Omega, R_{F}=681 \Omega$ for $\pm 15 \mathrm{~V}, 620 \Omega$ for $\pm 5 \mathrm{~V}$ and $\pm 2.5 \mathrm{~V}$


Figure 35. -3dB Bandwidth vs. Supply Voltage, Gain $=-1, R_{L}=150 \Omega$


Figure 32. Small Signal Pulse Response, Gain $=-1$, $R_{F}=681 \Omega, R_{L}=150 \Omega, V_{S}= \pm 5 \mathrm{~V}$


Figure 34. Closed-Loop Gain and Phase vs. Frequency, $G=-1, R_{L}=1 \mathrm{k} \Omega, R_{F}=681 \Omega$ for $V_{S}= \pm 15 \mathrm{~V}, 620 \Omega$ for $\pm 5 \mathrm{~V}$ and $\pm 2.5 \mathrm{~V}$


Figure 36. $-3 d B$ Bandwidth vs. Supply Voltage, Gain $=-1, R_{L}=1 \mathrm{k} \Omega$


Figure 37. Small Signal Pulse Response, Gain $=-10$, $R_{F}=442 \Omega, R_{L}=150 \Omega, V_{S}= \pm 15 \mathrm{~V}$


Figure 39. Closed-Loop Gain and Phase vs. Frequency, $G=-10, R_{L}=150 \Omega$


Figure 41. -3 dB Bandwidth vs. Supply Voltage, $G=-10, R_{L}=150 \Omega$


Figure 38. Large Signal Pulse Response, Gain $=-10$, $R_{F}=442 \Omega, R_{L}=400 \Omega, V_{S}= \pm 15 \mathrm{~V}$


Figure 40. Closed-Loop Gain and Phase vs. Frequency, $G=-10, R_{L}=1 \mathrm{k} \Omega$


Figure 42. $-3 d B$ Bandwidth vs. Supply Voltage, $G=-10, R_{L}=1 \mathrm{k} \Omega$

## GENERAL DESIGN CONSIDERATIONS

The AD810 is a current feedback amplifier optimized for use in high performance video and data acquisition systems. Since it uses a current feedback architecture, its closed-loop bandwidth depends on the value of the feedback resistor. Table I below contains recommended resistor values for some useful closedloop gains and supply voltages. As you can see in the table, the closed-loop bandwidth is not a strong function of gain, as it would be for a voltage feedback amp. The recommended resistor values will result in maximum bandwidths with less than 0.1 dB of peaking in the gain vs. frequency response.
The -3 dB bandwidth is also somewhat dependent on the power supply voltage. Lowering the supplies increases the values of internal capacitances, reducing the bandwidth. To compensate for this, smaller values of feedback resistor are sometimes used at lower supply voltages. The characteristic curves illustrate that bandwidths of over 100 MHz on 30 V total and over 50 MHz on 5 V total supplies can be achieved.

Table I. $\mathbf{- 3} \mathbf{d B}$ Bandwidth vs. Closed-Loop Gain and Resistance Values ( $\mathrm{R}_{\mathrm{L}}=\mathbf{1 5 0 \Omega}$ )

| $\mathbf{V}_{\mathbf{S}}= \pm \mathbf{1 5 ~ V}$ <br> Closed-Loop <br> Gain |  |  |  |
| :--- | :--- | :--- | :--- |
| +1 | $\mathbf{R}_{\mathbf{F B}}$ | $\mathbf{R}_{\mathbf{G}}$ | $\mathbf{- 3 ~ d B ~ B W}$ <br> $(\mathbf{M H z})$ |
| +2 | $1 \mathrm{k} \Omega$ |  | 80 |
| +10 | $715 \Omega$ | $715 \Omega$ | 75 |
| -1 | $270 \Omega$ | $30 \Omega$ | 65 |
| -10 | $681 \Omega$ | $681 \Omega$ | 70 |
| $\mathbf{V}_{\mathbf{S}}= \pm \mathbf{5} \mathbf{V}$ | $249 \Omega$ | $24.9 \Omega$ | 65 |
| Closed-Loop |  |  |  |
| Gain | $\mathbf{R}_{\mathbf{F B}}$ | $\mathbf{R}_{\mathbf{G}}$ | $-\mathbf{3 ~ d B ~ B W}$ |
| +1 | $910 \Omega$ |  | $(\mathbf{M H z})$ |
| +2 | $715 \Omega$ | $715 \Omega$ | 50 |
| +10 | $270 \Omega$ | $30 \Omega$ | 50 |
| -1 | $620 \Omega$ | $620 \Omega$ | 50 |
| -10 | $249 \Omega$ | $24.9 \Omega$ | 50 |

## ACHIEVING VERY FLAT GAIN RESPONSE AT HIGH FREQUENCY

Achieving and maintaining gain flatness of better than 0.1 dB above 10 MHz is not difficult if the recommended resistor values are used. The following issues should be considered to ensure consistently excellent results.

## CHOICE OF FEEDBACK AND GAIN RESISTOR

Because the 3 dB bandwidth depends on the feedback resistor, the fine scale flatness will, to some extent, vary with feedback resistor tolerance. It is recommended that resistors with a $1 \%$ tolerance be used if it is desired to maintain exceptional flatness over a wide range of production lots.

## PRINTED CIRCUIT BOARD LAYOUT

As with all wideband amplifiers, PC board parasitics can affect the overall close-loop performance. Most important are stray capacitances at the output and inverting input nodes. (An added capacitance of 2 pF between the inverting input and ground will add about 0.2 dB of peaking in the gain of 2 response, and increase the bandwidth to 105 MHz .) A space ( $3 / 16^{\prime \prime}$ is plenty) should be left around the signal lines to minimize coupling. Also, signal lines connecting the feedback and gain resistors should be short enough so that their associated inductance does not cause high frequency gain errors. Line lengths less than $1 / 4^{\prime \prime}$ are recommended.

## QUALITY OF COAX CABLE

Optimum flatness when driving a coax cable is possible only when the driven cable is terminated at each end with a resistor matching its characteristic impedance. If coax were ideal, then the resulting flatness would not be affected by the length of the cable. While outstanding results can be achieved using inexpensive cables, some variation in flatness due to varying cable lengths is to be expected.

## POWER SUPPLY BYPASSING

Adequate power supply bypassing can be critical when optimizing the performance of a high frequency circuit. Inductance in the power supply leads can contribute to resonant circuits that produce peaking in the amplifier's response. In addition, if large current transients must be delivered to the load, then bypass capacitors (typically greater than $1 \mu \mathrm{~F}$ ) will be required to provide the best settling time and lowest distortion. Although the recommended $0.1 \mu \mathrm{~F}$ power supply bypass capacitors will be sufficient in most applications, more elaborate bypassing (such as using two paralleled capacitors) may be required in some cases.

## POWER SUPPLY OPERATING RANGE

The AD810 will operate with supplies from $\pm 18 \mathrm{~V}$ down to about $\pm 2.5 \mathrm{~V}$. On $\pm 2.5 \mathrm{~V}$ the low distortion output voltage swing will be better than 1 V peak to peak. Single supply operation can be realized with excellent results by arranging for the input common-mode voltage to be biased at the supply midpoint.

## OFFSET NULLING

A $10 \mathrm{k} \Omega$ pot connected between Pins 1 and 5 , with its wiper connected to $\mathrm{V}+$, can be used to trim out the inverting input current (with about $\pm 20 \mu \mathrm{~A}$ of range). For closed-loop gains above about 5 , this may not be sufficient to trim the output offset voltage to zero. Tie the pot's wiper to ground through a large value resistor ( $50 \mathrm{k} \Omega$ for $\pm 5 \mathrm{~V}$ supplies, $150 \mathrm{k} \Omega$ for $\pm 15$ V supplies) to trim the output to zero at high closed-loop gains.

## CAPACITIVE LOADS

When used with the appropriate feedback resistor, the AD810 can drive capacitive loads exceeding 1000 pF directly without oscillation. By using the curves in Figure 45 to chose the resistor value, less than 1 dB of peaking can easily be achieved without sacrificing much bandwidth. Note that the curves were generated for the case of a $10 \mathrm{k} \Omega$ load resistor, for smaller load resistances, the peaking will be less than indicated by Figure 45.
Another method of compensating for large load capacitances is to insert a resistor in series with the loop output as shown in Figure 43. In most cases, less than $50 \Omega$ is all that is needed to achieve an extremely flat gain response.
Figures 44 to 46 illustrate the outstanding performance that can be achieved when driving a 1000 pF capacitor.


Figure 43. Circuit Options for Driving a Large Capacitive Load


Figure 44. Performance Comparison of Two Methods for Driving a Large Capacitive Load


Figure 45. Max Load Capacitance for Less than $1 d B$ of Peaking vs. Feedback Resistor


Figure 46. AD810 Driving a 1000 pF Load, Gain $=+2$, $R_{F}=750 \Omega, R_{S}=11 \Omega, R_{L}=10 \mathrm{k} \Omega$

## DISABLE MODE

By pulling the voltage on Pin 8 to common ( 0 V ), the AD810 can be put into a disabled state. In this condition, the supply current drops to less than 2.8 mA , the output becomes a high impedance, and there is a high level of isolation from input to output. In the case of a line driver for example, the output impedance will be about the same as for a $1.5 \mathrm{k} \Omega$ resistor (the feedback plus gain resistors) in parallel with a 13 pF capacitor (due to the output) and the input to output isolation will be better than 65 dB at 1 MHz .
Leaving the disable pin disconnected (floating) will leave the AD810 operational in the enabled state.

In cases where the amplifier is driving a high impedance load, the input to output isolation will decrease significantly if the input signal is greater than about 1.2 V peak to peak. The isolation can be restored back to the 65 dB level by adding a dummy load (say $150 \Omega$ ) at the amplifier output. This will attenuate the feedthrough signal. (This is not an issue for multiplexer applications where the outputs of multiple AD810s are tied together as long as at least one channel is in the ON state.) The input impedance of the disable pin is about $35 \mathrm{k} \Omega$ in parallel with a few pF . When grounded, about $50 \mu \mathrm{~A}$ flows out of the disable
the disable pin for $\pm 5 \mathrm{~V}$ supplies. If driven by complementary output CMOS logic (such as the 74 HC 04 ), the disable time (until the output goes high impedance) is about 100 ns and the enable time (to low impedance output) is about 170 ns on $\pm 5 \mathrm{~V}$ supplies. The enable time can be extended to about 750 ns by using open drain logic such as the 74 HC 05 .
When operated on $\pm 15 \mathrm{~V}$ supplies, the AD810 disable pin may be driven by open drain logic such as the 74 C 906 . In this case, adding a $10 \mathrm{k} \Omega$ pull-up resistor from the disable pin to the plus supply will decrease the enable time to about 150 ns . If there is a nonzero voltage present on the amplifier's output at the time it is switched to the disabled state, some additional decay time will be required for the output voltage to relax to zero. The total time for the output to go to zero will generally be about 250 ns and is somewhat dependent on the load impedance.

## OPERATION AS A VIDEO LINE DRIVER

The AD810 is designed to offer outstanding performance at closed-loop gains of one or greater. At a gain of 2, the AD810 makes an excellent video line driver. The low differential gain and phase errors and wide -0.1 dB bandwidth are nearly independent of supply voltage and load (as seen in Figures 49 and 50 ).


Figure 47. A Video Line Driver Operating at a Gain of +2


Figure 48. Closed-Loop Gain and Phase vs. Frequency, $G=+2, R_{L}=150, R_{F}=715 \Omega$


Figure 49. Differential Gain and Phase vs. Supply Voltage


Figure 50. Fine-Scale Gain (Normalized) vs. Frequency for Various Supply Voltages, Gain $=+2, R_{F}=715 \Omega$


Figure 51. $-3 d B$ Bandwidth vs. Supply Voltage, Gain $=+2, R_{L}=150 \Omega$

## 2:1 VIDEO MULTIPLEXER

The outputs of two AD810s can be wired together to form a 2:1 mux without degrading the flatness of the gain response. Figure 54 shows a recommended configuration which results in -0.1 dB bandwidth of 20 MHz and OFF channel isolation of 77 dB at 10 MHz on $\pm 5 \mathrm{~V}$ supplies. The time to switch between channels is about $0.75 \mu \mathrm{~s}$ when the disable pins are driven by open drain output logic. Adding pull-up resistors to the logic outputs or using complementary output logic (such as the 74 HC 04 ) reduces the switching time to about 180 ns . The switching time is only slightly affected by the signal level.


Figure 52. Channel Switching Time for the 2:1 Mux


Figure 53. 2:1 Mux OFF Channel Feedthrough vs. Frequency


Figure 54. A Fast Switching 2:1 Video Mux


Figure 55. 2:1 Mux ON Channel Gain and Phase vs. Frequency

## N:1 MULTIPLEXER

A multiplexer of arbitrary size can be formed by combining the desired number of AD810s together with the appropriate selection logic. The schematic in Figure 58 shows a recommendation for a $4: 1$ mux which may be useful for driving a high impedance such as the input to a video A/D converter (such as the AD773). The output series resistors effectively compensate for the combined output capacitance of the OFF channels plus the input capacitance of the A/D while maintaining wide bandwidth. In the case illustrated, the -0.1 dB bandwidth is about 20 MHz with no peaking. Switching time and OFF channel isolation (for the $4: 1 \mathrm{mux}$ ) are about 250 ns and 60 dB at 10 MHz , respectively.


Figure 56. 4:1 Mux ON Channel Gain and Phase vs. Frequency


Figure 57. 4:1 Mux OFF Channel Feedthrough vs. Frequency


Figure 58. A 4:1 Multiplexer Driving a High Impedance High Performance Video Op Amp AD811

## FEATURES

High Speed
140 MHz Bandwidth ( $3 \mathrm{~dB}, \mathrm{G}=+1$ )
120 MHz Bandwidth ( $3 \mathrm{~dB}, \mathrm{G}=+2$ )
35 MHz Bandwidth ( $0.1 \mathrm{~dB}, \mathrm{G}=+2$ )
2500 V/ $\mu \mathrm{s}$ Slew Rate
25 ns Settling Time to 0.1\% (For a 2 V Step)
65 ns Settling Time to $0.01 \%$ (For a 10 V Step)
Excellent Video Performance ( $\mathrm{R}_{\mathrm{L}}=150 \Omega$ ) 0.01\% Differential Gain, $0.01^{\circ}$ Differential Phase Voltage Noise of $1.9 \mathrm{nV} \sqrt{\mathrm{Hz}}$
Low Distortion: THD =-74 dB@10 MHz
Excellent DC Precision
3 mV max Input Offset Voltage
Flexible Operation
Specified for $\pm 5 \mathrm{~V}$ and $\pm 15 \mathrm{~V}$ Operation $\pm 2.3 \mathrm{~V}$ Output Swing into a $75 \Omega$ Load ( $\mathrm{V}_{\mathrm{s}}= \pm 5 \mathrm{~V}$ )

## APPLICATIONS

Video Crosspoint Switchers, Multimedia Broadcast Systems

## HDTV Compatible Systems

Video Line Drivers, Distribution Amplifiers
ADC/DAC Buffers
DC Restoration Circuits
Medical-Ultrasound, PET, Gamma \& Counter Applications

## PRODUCT DESCRIPTION

The AD811 is a wideband current-feedback operational amplifier, optimized for broadcast quality video systems. The -3 dB bandwidth of 120 MHz at a gain of +2 and differential gain and phase of $0.01 \%$ and $0.01^{\circ}\left(\mathrm{R}_{\mathrm{L}}=150 \Omega\right)$ make the AD811 an excellent choice for all video systems. The AD811 is designed to meet a stringent 0.1 dB gain flatness specification to a bandwidth of $35 \mathrm{MHz}(\mathrm{G}=+2)$ in addition to the low differential gain and phase errors. This performance is achieved whether driving one or two back terminated $75 \Omega$ cables, with a low power supply current of 16.5 mA . Furthermore, the AD811 is specified over a power supply range of $\pm 4.5 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$.

## CONNECTION DIAGRAMS

8-Pin Plastic ( $\mathrm{N}-8$ ),
20-Pin LCC (E-20A) Package
Cerdip (Q-8) and
SOIC (R-8) Packages


16-Pin SOIC (R-16) Package


20-Pin SOIC (R-20) Package


The AD811 is also excellent for pulsed applications where transient response is critical. It can achieve a maximum slew rate of greater than $2500 \mathrm{~V} / \mu \mathrm{s}$ with a settling time of less than 25 ns to $0.1 \%$ on a 2 volt step and 65 ns to $0.01 \%$ on a 10 volt step.
The AD811 is ideal as an ADC or DAC buffer in data acquisition systems due to its low distortion up to 10 MHz and its wide unity gain bandwidth. Because the AD811 is a current feedback amplifier, this bandwidth can be maintained over a wide range of gains. The AD811 also offers low voltage and current noise of $1.9 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ and $20 \mathrm{pA} / \sqrt{\mathrm{Hz}}$, respectively, and excellent dc accuracy for wide dynamic range applications.


This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

AD\&11-SPEGMFAMTONS $\left(T_{A}=+25^{\circ} \mathrm{C}\right.$ and $V_{S}= \pm 15 V \mathrm{dc}, \mathrm{R}_{\text {LOAD }}=150 \Omega$ unless otherwise noted)


## NOTES

${ }^{1}$ The AD811JR is specified with $\pm 5 \mathrm{~V}$ power supplies only, with operation up to $\pm 12$ volts.
${ }^{2}$ See Analog Devices' military data sheet for 883B tested specifications.
${ }^{3}$ FPBW $=$ slew rate/( $2 \pi \mathrm{~V}_{\text {PEAK }}$ )
${ }^{4}$ Output power level, tested at a closed loop gain of two.
${ }^{\text {s }}$ Useful operating range is defined as the output voltage at which linearity begins to degrade.
Specifications subject to change without notice.

| ABSOLUTE MAXIMUM RATINGS ${ }^{1}$ |
| :---: |
| Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . $\pm 18$ V |
| AD811JR Grade Only . . . . . . . . . . . . . . . . . . . . $\pm 12 \mathrm{~V}$ |
| Internal Power Dissipation ${ }^{2}$. . . . . . Observe Derating Curves |
| Output Short Circuit Duration . . . . Observe Derating Curves |
| Common-Mode Input Voltage . . . . . . . . . . . . . . . . $\pm \mathrm{V}_{\text {S }}$ |
| Differential Input Voltage . . . . . . . . . . . . . . . . . . $\pm 6$ V |
| Storage Temperature Range (Q, E) . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Storage Temperature Range (N, R) . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Operating Temperature Range |
| AD811J . . . . . . . . . . . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ |
| AD811A . . . . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| AD811S . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Lead Temperature Range (Soldering 60 sec ) . . . . . . $+300^{\circ} \mathrm{C}$ |
| NOTES |
| ${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. |
| ${ }^{2} 8$-Pin Plastic Package: $\theta_{\mathrm{JA}}=90^{\circ} \mathrm{C} / \mathrm{Watt}$ |
| 8-Pin Cerdip Package: $\theta_{\mathrm{JA}}=110^{\circ} \mathrm{C} / \mathrm{W}$ att |
| 8 -Pin SOIC Package: $\theta_{\text {JA }}=155^{\circ} \mathrm{C} /$ Watt |
| 16-Pin SOIC Package: $\theta_{\text {JA }}=85^{\circ} \mathrm{C} /$ Watt |
| 20-Pin SOIC Package: $\theta_{\text {JA }}=80^{\circ} \mathrm{C} / \mathrm{W}^{\text {att }}$ |
| 20-Pin LCC Package: $\theta_{\text {JA }}=70^{\circ} \mathrm{C} / \mathrm{W}$ att |

ORDERING GUIDE

| Model | Temperature Range | Package |
| :--- | :--- | :--- |
| AD811AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| AD811AR-16 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16$ |
| AD811AR-20 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-20$ |
| AD811JR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{R}-8$ |
| AD811SQ/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |
| $5962-9313001 \mathrm{MPA}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |
| AD811SE/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{E}-20 \mathrm{~A}$ |
| 5962-9313001M2A | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | E-20A |
| AD811ACHIPS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Die |
| AD811SCHIPS | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Die |

[^139]
## MAXIMUM POWER DISSIPATION

The maximum power that can be safely dissipated by the AD811 is limited by the associated rise in junction temperature. For the plastic packages, the maximum safe junction temperature is $145^{\circ} \mathrm{C}$. For the cerdip and LCC packages, the maximum junction temperature is $175^{\circ} \mathrm{C}$. If these maximums are exceeded momentarily, proper circuit operation will be restored as soon as the die temperature is reduced. Leaving the device in the "overheated" condition for an extended period can result in device burnout. To ensure proper operation, it is important to observe the derating curves in Figures 17 and 18.

While the AD811 is internally short circuit protected, this may not be sufficient to guarantee that the maximum junction temperature is not exceeded under all conditions. One important example is when the amplifier is driving a reverse terminated $75 \Omega$ cable and the cable's far end is shorted to a power supply. With power supplies of $\pm 12$ volts (or less) at an ambient temperature of $+25^{\circ} \mathrm{C}$ or less, if the cable is shorted to a supply rail, then the amplifier will not be destroyed, even if this condition persists for an extended period.

## ESD SUSCEPTIBILITY

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 volts, which readily accumulate on the human body and on test equipment, can discharge without detection. Although the AD811 features proprietary ESD protection circuitry, permanent damage may still occur on these devices if they are subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid any performance degradation or loss of functionality.

## METALIZATION PHOTOGRAPH

Contact Factory for Latest Dimensions.
Dimensions Shown in Inches and (mm).


## FEATURES

Two Video Amplifiers in One 8-Pin SOIC Package
Optimized for Driving Cables in Video Systems
Excellent Video Specifications ( $\mathrm{R}_{\mathrm{L}}=150 \Omega$ ):
Gain Flatness 0.1 dB to $\mathbf{4 0} \mathbf{~ M H z}$
0.02\% Differential Gain Error
$0.02^{\circ}$ Differential Phase Error
Low Power
Operates on Single +3 V Supply
$5.5 \mathrm{~mA} /$ Amplifier Max Power Supply Current
High Speed
145 MHz Unity Gain Bandwwidth (3 dB) 1600 V/us Slew Rate
Easy to Use
50 mA Output Current Output Swing to 1 V of Rails ( $150 \Omega$ Load)

## APPLICATIONS

Video Line Driver
Professional Cameras
Video Switchers
Special Effects

## PRODUCT DESCRIPTION

The AD812 is a low power, single supply, dual video amplifier. Each of the amplifiers have 50 mA of output current and are optimized for driving one back terminated video load ( $150 \Omega$ ) each. Each amplifier is a current feedback amplifier and features gain flatness of 0.1 dB to 40 MHz while offering differential gain and phase error of $0.02 \%$ and $0.02^{\circ}$. This makes the AD812 ideal for professional video electronics such as cameras and video switchers.


Fine-Scale Gain Flatness vs. Frequency, Gain $=+2$, $R_{L}=150 \Omega$

## PIN CONFIGURATION

8-Pin Plastic
Mini-DIP \& SOIC


The AD812 offers low power of 4.0 mA per amplifier max $\left(\mathrm{V}_{\mathrm{s}}=\right.$ +5 V ) and can run on a single +3 V power supply. The outputs of each amplifier swing to within one volt of either supply rail to easily accommodate video signals of $1 \mathrm{Vp}-\mathrm{p}$. Also, at gains of +2 the AD812 can swing 3 V p-p on a single +5 V power supply. All this is offered in a small 8-pin plastic DIP or 8-pin SOIC package. These features make this dual amplifier ideal for portable and battery powered applications where size and power is critical.
The outstanding bandwidth of 145 MHz along with $1600 \mathrm{~V} / \mu \mathrm{s}$ of slew rate make the AD812 useful in many general purpose high speed applications where a single +5 V or dual power supplies up to $\pm 15 \mathrm{~V}$ are available. The AD812 is available in the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.


Differential Gain and Phase vs. Supply Voltage, Gain = +2, $R_{L}=150 \Omega$

Dual Supply ( $\odot \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{R}_{\mathrm{L}}=150 \Omega$, unless otherwise noted)


## AD812 - SPECIFICATIONS

## Dual Supply (Continued)

| Model | Conditions | $\mathbf{V}_{\text {s }}$ | AD812A |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max |  |
| OUTPUT CHARACTERISTICS |  |  |  |  |  |  |
| Output Voltage Swing | $\mathrm{R}_{\mathrm{L}}=150 \Omega, \mathrm{~T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ | $\pm 5 \mathrm{~V}$ | 3.5 | 3.8 |  | $\pm \mathrm{V}$ |
|  | $\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega, \mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ | $\pm 15 \mathrm{~V}$ | 13.6 | 14.0 |  | $\pm \mathrm{V}$ |
| Output Current |  | $\pm 5 \mathrm{~V}$ | 30 | 40 |  | mA |
|  |  | $\pm 15 \mathrm{~V}$ | 40 | 50 |  | mA |
| Short Circuit Current | $\mathrm{G}=+2, \mathrm{R}_{\mathrm{F}}=715 \Omega$ | $\pm 15 \mathrm{~V}$ |  | 100 |  | mA |
|  | $\mathrm{V}_{\text {IN }}=2 \mathrm{~V}$ |  |  |  |  |  |
| Output Resistance | Open-Loop | $\pm 15 \mathrm{~V}$ |  | 15 |  | $\Omega$ |
| MATCHING CHARACTERISTICS |  |  |  |  |  |  |
| Dynamic |  |  |  |  |  |  |
| Crosstalk | $\mathrm{G}=+2, \mathrm{f}=5 \mathrm{MHz}$ | $\pm 5 \mathrm{~V}, \pm 15 \mathrm{~V}$ |  | -75 |  | dB |
| Gain Flatness Match | $\mathrm{G}=+2, \mathrm{f}=40 \mathrm{MHz}$ | $\pm 15 \mathrm{~V}$ |  | 0.1 |  | dB |
| DC |  |  |  |  |  |  |
| Input offset Voltage | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ | $\pm 5 \mathrm{~V}, \pm 15 \mathrm{~V}$ |  | 0.5 | 3.6 | mV |
| -Input Bias Current | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ | $\pm 5 \mathrm{~V}, \pm 15 \mathrm{~V}$ |  | 2 | 16 | $\mu \mathrm{A}$ |
| POWER SUPPLY |  |  |  |  |  |  |
| Operating Range |  |  | $\pm 1.2$ |  | $\pm 18$ | V |
| Quiescent Current | Per Amplifier | $\pm 5 \mathrm{~V}$ |  | 3.5 | 4.0 | mA |
|  |  | $\pm 15 \mathrm{~V}$ |  | 4.5 | 5.5 | mA |
|  | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ | $\pm 15 \mathrm{~V}$ |  |  | 6.0 | mA |
| Power Supply Rejection Ratio |  |  |  |  |  |  |
| Input Offset Voltage | $\mathrm{V}_{\mathrm{s}}= \pm 1.5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$ |  | 72 | 80 |  | dB |
| -Input Current |  |  |  | 0.3 | 0.6 | $\mu \mathrm{A} / \mathrm{V}$ |
| +Input Current |  |  |  | 0.005 | 0.05 | $\mu \mathrm{A} / \mathrm{V}$ |

## Single Supply ( $\Theta \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{R}_{\mathrm{L}}=150 \Omega$, unless otherwise noted)



## AD812 - SPECIFICATIONS

Single Supply (Continued)

|  |  |  |  | AD812A <br> Typ | Max |
| :--- | :--- | :--- | :--- | :--- | :--- | Units

NOTES
${ }^{1}$ Slew rate measurement is based on $10 \%$ to $90 \%$ rise time in the specified closed-loop gain.
${ }^{2}$ Single supply differential gain and phase are measured with the ac coupled circuit of Figure 50
Specifications subject to change without notice.

ABSOLUTE MAXIMUM RATINGS ${ }^{1}$
Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 18$ V Internal Power Dissipation ${ }^{2}$

Plastic (N) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 1.3 Watts
Small Outline (R) . . . . . . . . . . . . . . . . . . . . . . . . . 0.9 Watts
Input Voltage (Common Mode) . . . . . . . . . . . . . . . . . . . $\pm \mathrm{V}_{\mathrm{S}}$
Differential Input Voltage . . . . . . . . . . . . . . . . . . . . . . . . $\pm 1.2 \mathrm{~V}$
Output Short Circuit Duration
. . . . . . . . . . . . . . . . . . . . . Observe Power Derating Curves
Storage Temperature Range N, R . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Operating Temperature Range . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Lead Temperature Range (Soldering 10 seconds) $\ldots+300^{\circ} \mathrm{C}$

## NOTES

'Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ Specification is for device in free air: 8-Pin Plastic Package: $\theta_{\mathrm{JA}}=90^{\circ} \mathrm{C} / \mathrm{Watt}$; 8 -Pin SOIC Package: $\theta_{J A}=140^{\circ} \mathrm{C} /$ Watt.

## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option <br> $\star$ |
| :--- | :--- | :--- | :--- |
| AD812AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | N-8 |
| AD812AR-8 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | R-8 |

*For outline information see Package Information section.

## METALIZATION PHOTO

Dimensions shown in inches and (mm).


## MAXIMUM POWER DISSIPATION

The maximum power that can be safely dissipated by the AD812 is limited by the associated rise in junction temperature. The maximum safe junction temperature for the plastic encapsulated parts is determined by the glass transition temperature of the plastic, about $150^{\circ} \mathrm{C}$. Exceeding this limit temporarily may cause a shift in parametric performance due to a change in the stresses exerted on the die by the package. Exceeding a junction temperature of $175^{\circ} \mathrm{C}$ for an extended period can result in device failure.
While the AD812 is internally short circuit protected, this may not be sufficient to guarantee that the maximum junction temperature ( 150 degrees) is not exceeded under all conditions. To ensure proper operation, it is important to observe the derating curves.
It must also be noted that in high (noninverting) gain configurations (with low values of gain resistor), a high level of input overdrive can result in a large input error current, which may result in a significant power dissipation in the input stage. This power must be included when computing the junction temperature rise due to total internal power.


Plot of Maximum Power Dissipation vs. Temperature

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD812 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



Figure 1. Input Common-Mode Voltage Range vs. Supply Voltage


Figure 2. Output Voltage Swing vs. Supply


Figure 3. Output Voltage Swing vs. Load Resistance


Figure 4. Total Supply Current vs. Junction Temperature


Figure 5. Total Supply Current vs. Supply Voltage


Figure 6. Input Bias Current vs. Junction Temperature


Figure 7. Input Offset Voltage vs. Junction Temperature


Figure 8. Short Circuit Current vs. Junction Temperature


Figure 9. Linear Output Current vs. Junction Temperature


Figure 10. Linear Output Current vs. Supply Voltage


Figure 11. Closed-Loop Output Resistance vs. Frequency


Figure 12. Large Signal Frequency Response


Figure 13. Input Current and Voltage Noise vs. Frequency


Figure 14. Common-Mode Rejection vs. Frequency


Figure 15. Power Supply Rejection vs. Frequency


Figure 16. Open-Loop Transimpedance vs. Frequency (Relative to $1 \Omega$ )


Figure 17. Harmonic Distortion vs. Frequency


Figure 18. Output Swing and Error vs. Settling Time


Figure 19. Slew Rate vs. Output Step Size


Figure 20. Large Signal Pulse Response, Gain $=+1$, $\left(R_{F}=750 \Omega, R_{L}=150 \Omega, V_{S}= \pm 5 \mathrm{~V}\right)$


Figure 21. Closed-Loop Gain and Phase vs. Frequency, $G=+1$


Figure 22. Maximum Slew Rate vs. Supply Voltage


Figure 23. Small Signal Pulse Response, Gain $=+1$, $\left(R_{F}=750 \Omega, R_{L}=150 \Omega, V_{s}= \pm 5 \mathrm{~V}\right)$


Figure 24. $-3 d B$ Bandwidth vs. Supply Voltage, $G=+1$


Figure 25. Large Signal Pulse Response, Gain $=+10$, ( $R_{F}=357 \Omega, R_{L}=500 \Omega, V_{s}= \pm 15 \mathrm{~V}$ )


Figure 26. Closed-Loop Gain and Phase vs. Frequency, Gain $=+10, R_{L}=150 \Omega$


Figure 27. -3 dB Bandwidth vs. Supply Voltage, Gain $=+10, R_{L}=150 \Omega$


Figure 28. Small Signal Pulse Response, Gain $=+10$, $\left(R_{F}=357 \Omega, R_{L}=150 \Omega, V_{s}= \pm 5 \mathrm{~V}\right)$


Figure 29. Closed-Loop Gain and Phase vs. Frequency, Gain $=+10, R_{L}=1 \mathrm{k} \Omega$


Figure 30. $-3 d B$ Bandwidth vs. Supply Voltage, Gain $=+10, R_{L}=1 \mathrm{k} \Omega$


Figure 31. Large Signal Pulse Response, Gain $=-1$, $\left(R_{F}=750 \Omega, R_{L}=150 \Omega, V_{S}= \pm 5 \mathrm{~V}\right)$


Figure 32. Closed-Loop Gain and Phase vs. Frequency, Gain $=-1, R_{L}=150 \Omega$


Figure 33. $-3 d B$ Bandwidth vs. Supply Voltage, Gain $=-1, R_{L}=150 \Omega$


Figure 34. Small Signal Pulse Response, Gain $=-1$, $\left(R_{F}=750 \Omega, R_{L}=150 \Omega, V_{S}= \pm 5 \mathrm{~V}\right)$


Figure 35. Closed-Loop Gain and Phase vs. Frequency, Gain $=-10, R_{L}=1 \mathrm{k} \Omega$


Figure 36. $-3 d B$ Bandwidth vs. Supply Voltage, Gain $=-10, R_{L}=1 \mathrm{k} \Omega$

## General Considerations

The AD812 is a wide bandwidth, dual video amplifier which offers a high level of performance on less than 5.5 mA per amplifier of quiescent supply current. It is designed to offer outstanding performance at closed-loop inverting or noninverting gains of one or greater.

Built on a low cost, complementary bipolar process, and achieving bandwidth in excess of 100 MHz , differential gain and phase errors of better than $0.1 \%$ and $0.1^{\circ}$ (into $150 \Omega$ ), and output current greater than 40 mA , the AD812 is an exceptionally efficient video amplifier. Using a conventional current feedback architecture, its high performance is achieved through careful attention to design details.

## Choice of Feedback \& Gain Resistors

Because it is a current feedback amplifier, the closed-loop bandwidth of the AD812 depends on the value of the feedback resistor. The bandwidth also depends on the supply voltage. In addition, attenuation of the open-loop response when driving load resistors less than about $250 \Omega$ will affect the bandwidth. Table I contains data showing typical bandwidths at different supply voltages for some useful closed-loop gains when driving a load of $150 \Omega$. (Bandwidths will be about $20 \%$ greater for load resistances above a few hundred ohms.)

The choice of feedback resistor is not critical unless it is important to maintain the widest, flattest frequency response. The resistors recommended in the table are those (metal film values) that will result in the widest 0.1 dB bandwidth. In those applications where the best control of the bandwidth is desired, $1 \%$ metal film resistors are adequate. Wider bandwidths can be attained by reducing the magnitude of the feedback resistor (at the expense of increased peaking), while peaking can be reduced by increasing the magnitude of the feedback resistor.
Table I. -3 dB Bandwidth vs. Closed-Loop Gain and Feedback Resistor ( $\mathrm{R}_{\mathrm{L}}=150 \Omega$ )

| $\mathbf{V}_{\mathbf{s}}$ | Gain | $\mathbf{R}_{\mathbf{F}}, \Omega$ | $\mathbf{B W}, \mathbf{M H z}$ |
| :--- | :--- | :--- | :---: |
| $\pm \mathbf{1 5} \mathbf{V}$ | $\mathbf{+ 1}$ | 866 | 145 |
|  | +2 | 715 | 100 |
|  | +10 | 357 | 65 |
|  | -1 | 715 | 100 |
|  | -10 | 357 | 60 |
| $\pm \mathbf{5} \mathbf{V}$ | +1 | 750 | 90 |
|  | +2 | 681 | 65 |
|  | +10 | 154 | 45 |
|  | -1 | 715 | 70 |
|  | -10 | 154 | 45 |
| $\mathbf{+ 5} \mathbf{V}$ | +1 | 750 | 60 |
|  | +2 | 681 | 50 |
|  | +10 | 154 | 35 |
|  | -1 | 715 | 50 |
|  | -10 | 154 | 35 |
| $\mathbf{+ 3} \mathbf{V}$ | +1 | 750 | 50 |
|  | +2 | 681 | 40 |
|  | +10 | 154 | 30 |
|  | -1 | 715 | 40 |
|  | -10 | 154 | 25 |

To estimate the -3 dB bandwidth for closed-loop gains or feedback resistors not listed in the above table, the following two pole model for the AD812 many be used:

$$
A_{C L}=\frac{G}{S^{2}\left[\frac{\left.\left(R_{F}+G r_{I N}\right) C_{T}\right]}{2 \pi f_{2}}\right]+\mathrm{S}\left(R_{F}+G r_{I N}\right) C_{T}+1}
$$

where: $\quad \mathrm{A}_{\mathrm{CL}}=$ closed-loop gain
$\mathrm{G}=1+\mathrm{R}_{\mathrm{F}} / \mathrm{R}_{\mathrm{G}}$
$\mathrm{r}_{\text {in }}=$ input resistance of the inverting input
$\mathrm{C}_{\mathrm{T}}$ = "transcapacitance," which forms the open-loop
dominant pole with the tranresistance
$\mathrm{R}_{\mathrm{F}}=$ feedback resistor
$\mathrm{R}_{\mathrm{G}}=$ gain resistor
$\mathrm{f}_{2}=$ frequency of second (non-dominant) pole
$\mathrm{S}=2 \pi j f$
Appropriate values for the model parameters at different supply voltages are listed in Table II. Reasonable approximations for these values at supply voltages not found in the table can be obtained by a simple linear interpolation between those tabulated values which "bracket" the desired condition.

## Table II. Two-Pole Model Parameters at Various Suppy Voltages

| $\mathbf{V}_{\mathbf{s}}$ | $\mathbf{r}_{\text {IN }}(\Omega)$ | $\mathbf{C}_{\mathrm{T}}(\mathbf{p F})$ | $\mathbf{f}_{\mathbf{2}}(\mathbf{M H z})$ |
| :--- | :--- | :--- | :---: |
| $\pm \mathbf{1 5}$ | 85 | 2.5 | 150 |
| $\pm \mathbf{5}$ | 90 | 3.8 | 125 |
| $\mathbf{+ 5}$ | 105 | 4.8 | 105 |
| $\mathbf{+ 3}$ | 115 | 5.5 | 95 |

As discussed in many amplifier and electronics textbooks (such as Roberge's Operational Amplifiers: Theory and Practice), the -3 dB bandwidth for the 2-pole model can be obtained as:

$$
f_{3}=f_{N}\left[1-2 d^{2}+\left(2-4 d^{2}+4 d^{4}\right)^{1 / 2}\right]^{1 / 2}
$$

where:

$$
f_{N}=\left[\frac{f_{2}}{\left(R_{F}+G r_{I N}\right) C_{T}}\right]^{1 / 2}
$$

and:

$$
d=(1 / 2)\left[f_{2}\left(R_{F}+G r_{I N}\right) C_{T}\right]^{1 / 2}
$$

This model will predict -3 dB bandwidth within about 10 to $15 \%$ of the correct value when the load is $150 \Omega$. However, it is not an accurate enough to predict either the phase behavior or the frequency response peaking of the AD812.

## Printed Circuit Board Layout Guidelines

As with all wideband amplifiers, printed circuit board parasitics can affect the overall closed-loop performance. Most important for controlling the 0.1 dB bandwidth are stray capacitances at the output and inverting input nodes. Increasing the space between signal lines and ground plane will minimize the coupling. Also, signal lines connecting the feedback and gain resistors should be kept short enough that their associated inductance does not cause high frequency gain errors.

## Power Supply Bypassing

Adequate power supply bypassing can be very important when optimizing the performance of high speed circuits. Inductance in the supply leads can (for example) contribute to resonant circuits that produce peaking in the amplifier's response. In addition, if large current transients must be delivered to a load, then large (greater than $1 \mu \mathrm{~F}$ ) bypass capacitors are required to produce the best settling time and lowest distortion. Although $0.1 \mu \mathrm{~F}$ capacitors may be adequate in some applications, more elaborate bypassing is required in other cases.
When multiple bypass capacitors are connected in parallel, it is important to be sure that the capacitors themselves do not form resonant circuits. A small (say $5 \Omega$ ) resistor may be required in series with one of the capacitors to minimize this possibility.
As discussed below, power supply bypassing can have a significant impact on crosstalk performance.

## Achieving Low Crosstalk

Measured crosstalk from the output of amplifier 2 to the input of amplifier 1 of the AD812 is shown in Figure 37. The crosstalk from the output of amplifier 1 to the input of amplifier 2 is a few dB better than this due to the additional distance between critical signal nodes.
A carefully laid-out PC board should be able to achieve the level of crosstalk shown in the figure. The most significant contributors to difficulty in achieving low crosstalk are inadequate power supply bypassing, overlapped input and/or output signal paths, and capacitive coupling between critical nodes.

The bypass capacitors must be connected to the ground plane at a point close to and between the ground reference points for the two loads. (The bypass of the negative power supply is particularly important in this regard.) There are two amplifiers in the package, and low impedance signal return paths must be provided for each load. (Using a parallel combination of $1 \mu \mathrm{~F}, 0.1 \mu \mathrm{~F}$, and $0.01 \mu \mathrm{~F}$ bypass capacitors will help to achieve optimal crosstalk.)


Figure 37. Crosstalk vs. Frequency

The input and output signal return paths must also be kept from overlapping. Since ground connections are not of perfectly zero impedance, current in one ground return path can produce a voltage drop in another ground return path if they are allowed to overlap.
Electric field coupling external to (and across) the package can be reduced by arranging for a narrow strip of ground plane to be run between the pins (parallel to the pin rows). Doing this on both sides of the board can reduce the high frequency crosstalk by about 5 dB or 6 dB .

## Driving Capacitive Loads

When used with the appropriate output series resistor, any load capacitance can be driven without peaking or oscillation. In most cases, less than $50 \Omega$ is all that is needed to achieve an extremely flat frequency response. As illustrated in Figure 41, the AD812 can be very attractive for driving largely capacitive loads. In this case, the AD812's high output short circuit current allows for a $150 \mathrm{~V} / \mu \mathrm{s}$ slew rate when driving a 510 pF capacitor.


Figure 38. Circuit for Driving a Capacitive Load


Figure 39. Response to a Small Load Capacitor at $\pm 5$ V


Figure 40. Response to Large Load Capacitor, $V_{s}= \pm 15$ V


Figure 41. Pulse Response of Circuit of Figure 38 with $C_{L}=510 \mathrm{pF}, R_{L}=1 \mathrm{k} \Omega, R_{F}=R_{G}=715 \Omega, R_{s}=15 \Omega$

## Overload Recovery

There are three important overload conditions to consider. They are due to input common mode voltage overdrive, input current overdrive, and output voltage overdrive. When the amplifier is configured for low closed-loop gains, and its input common-mode voltage range is exceeded, the recovery time will be very fast, typically under 10 ns . When configured for a higher gain, and overloaded at the output, the recovery time will also be short. For example, in a gain of +10 , with 6 dB of input overdrive, the recovery time of the AD812 is about 10 ns .


Figure 42. 6 dB Overload Recovery; $G=10$, $R_{L}=500 \Omega, V_{s}= \pm 5 \mathrm{~V}$

In the case of high gains with very high levels of input overdrive, a longer recovery time may occur. For example, if the input common-mode voltage range is exceeded in a gain of +10 , the recovery time will be on the order of 100 ns . This is primarily due to current overloading of the input stage.
As noted in the warning under "Maximum Power Dissipation", a high level of input overdrive in a high noninverting gain circuit can result in a large current flow in the input stage. For differential input voltages of less than about 1.25 V , this will be internally limited to less than 20 mA (decreasing with supply voltage). For input overdrives which result in higher differential input voltages, power dissipation in the input stage must be considered. It is recommended that external diode clamps be used in cases where the differential input voltage is expected to exceed 1.25 V .

## High Performance Video Line Driver

At a gain of +2 , the AD812 makes an excellent driver for a back terminated $75 \Omega$ video line. Low differential gain and phase errors and wide 0.1 dB bandwidth can be realized over a wide range of power supply voltage. Outstanding gain and group delay matching are also attainable over the full operating supply voltage range.


Figure 43. Gain of +2 Video Line Driver $\left(R_{F}=R_{G}\right.$ from Table I)


Figure 44. Closed-Loop Gain and Phase vs. Frequency for the Line Driver


Figure 45. $-3 d B$ Bandwidth vs. Supply Voltage,
Gain $=+2, R_{L}=150 \Omega$


Figure 46. Differential Gain and Phase vs. Supply Voltage, Gain $=+2, R_{L}=150 \Omega$


Figure 47. Fine-Scale Gain Flatness vs. Frequency, Gain $=+2, R_{L}=150 \Omega$


Figure 48. Closed-Loop Gain Matching vs. Frequency, Gain $=+2, R_{L}=150 \Omega$


Figure 49. Group Delay and Group Delay Matching vs. Frequency, $G=+2, R_{L}=150 \Omega$

## AD812

## Operation Using a Single Supply

The AD812 will operate with total supply voltages from 36 V down to 2.4 V . With proper biasing (see Figure 50), it can be an outstanding single supply video amplifier. Since the input and output voltage ranges extend to within 1 volt of the supply rails, it will handle a 1.3 V p-p signal on a single 3.3 V supply, or a 3 V p-p signal on a single 5 V supply. The small signal, 0.1 dB bandwidths will exceed 10 MHz in either case, and the large signal bandwidths will exceed 6 MHz .

The capacitively coupled cable driver in Figure 50 will achieve outstanding differential gain and phase errors of $0.07 \%$ and 0.06 degrees respectively on a single 5 V supply. Resistor R2, in this circuit, is selected to optimize the differential gain and phase by operating the amplifier in its most linear region. To optimize the circuit for a 3 V supply, a value of $8 \mathrm{k} \Omega$ is recommended for R 2 .


Figure 50. Biasing For Single Supply Operation


Figure 51. Closed-Loop Gain and Phase vs. Frequency, Circuit of Figure 50


Figure 52. Pulse Response of the Circuit of Figure 50 with $V_{s}=5 \mathrm{~V}$

## FEATURES

Low Cost
Three Video Amplifiers in One Package Optimized for Driving Cables in Video Systems
Excellent Video Specifications ( $\mathrm{R}_{\mathrm{L}}=150 \Omega$ )
Gain Flatness $\mathbf{0 . 1} \mathbf{d B}$ to $\mathbf{5 0} \mathbf{~ M H z}$
0.03\% Differential Gain Error
$0.06{ }^{\circ}$ Differential Phase Error
Low Power
Operates on Single +3 V to $\pm 15$ V Power Supplies
5.5 mA/Amplifier Max Power Supply Current

High Speed
125 MHz Unity Gain Bandwidth (-3 dB)
500 V/ $\mu \mathrm{s}$ Slew Rate
High Speed Disable Function per Channel
Turn-Off Time 80 ns
Easy to Use
50 mA Output Current
Output Swing to 1 V of Rails
APPLICATIONS
Video Line Driver
LCD Drivers
Computer Video Plug-In Boards
Ultrasound
RGB Amplifier
CCD Based Systems

## PRODUCT DESCRIPTION

The AD813 is a low power, single supply triple video amplifier. Each of the three current feedback amplifiers has 50 mA of output current, and is optimized for driving one back terminated video load ( $150 \Omega$ ). The AD813 features gain flatness of 0.1 dB to


Fine-Scale Gain Flatness vs. Frequency, $G=+2, R_{L}=150 \Omega$

## PIN CONFIGURATION

14-Pin DIP \& SOIC Package


50 MHz while offering differential gain and phase error of $0.03 \%$ and $0.06^{\circ}$. This makes the AD813 ideal for broadcast and consumer video electronics.

The AD813 offers low power of 5.5 mA per amplifier max and runs on a single +3 V power supply. The outputs of each amplifier swing to within one volt of either supply rail to easily accommodate video signals. While operating on a single +5 V supply the AD813 still achieves 0.1 dB flatness to 20 MHz and $0.05 \% \& 0.05^{\circ}$ of differential gain and phase performance. All this is offered in a small 14-pin plastic DIP or SOIC package. These features make this triple amplifier ideal for portable and battery powered applications where size and power are critical.
The outstanding bandwidth of 125 MHz along with $500 \mathrm{~V} / \mu \mathrm{s}$ of slew rate make the AD813 useful in many general purpose, high speed applications where a single +3 V or dual power supplies up to $\pm 15 \mathrm{~V}$ are needed. Furthermore the AD813 contains a high speed disable function for each amplifier in order to power down the amplifier or high impedance the output. This can then be used in video multiplexing applications. The AD813 is available in the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ in plastic DIP and SOIC packages as well as chips.


Channel Switching Characteristics for a 3:1 Mux

## AD813-SPECIFICATIONS

Dual Supply (@ $\mathrm{I}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{R}_{\mathrm{L}}=150 \Omega$, unless otherwise noted)


\begin{tabular}{|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Model} \& \multirow[b]{2}{*}{Conditions} \& \multirow[b]{2}{*}{\(\mathbf{V}_{\text {s }}\)} \& \multicolumn{3}{|c|}{AD813A} \& \multirow[b]{2}{*}{Units} \\
\hline \& \& \& Min \& Typ \& Max \& \\
\hline \begin{tabular}{l}
OUTPUT CHARACTERISTICS \\
Output Voltage Swing \\
Output Current \\
Short Circuit Current
\end{tabular} \& \[
\begin{aligned}
\& \mathrm{R}_{\mathrm{L}}=150 \Omega, \mathrm{~T}_{\mathrm{MIN}}-\mathrm{T}_{\mathrm{MAX}} \\
\& \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega, \mathrm{~T}_{\mathrm{MIN}^{-}}-\mathrm{T}_{\mathrm{MAX}}
\end{aligned}
\]
\[
\begin{aligned}
\& \mathrm{G}=+2, \mathrm{R}_{\mathrm{F}}=715 \Omega \\
\& \mathrm{~V}_{\mathrm{IN}}=2 \mathrm{~V}
\end{aligned}
\] \& \[
\begin{aligned}
\& \pm 5 \mathrm{~V} \\
\& \pm 15 \mathrm{~V} \\
\& \pm 5 \mathrm{~V} \\
\& \pm 15 \mathrm{~V} \\
\& \pm 15 \mathrm{~V}
\end{aligned}
\] \& \[
\begin{aligned}
\& 3.5 \\
\& 13.6 \\
\& 25 \\
\& 30
\end{aligned}
\] \& \[
\begin{aligned}
\& 3.8 \\
\& 14.0 \\
\& 40 \\
\& 50 \\
\& 100
\end{aligned}
\] \& \& \[
\begin{aligned}
\& \pm \mathrm{V} \\
\& \pm \mathrm{V} \\
\& \mathrm{~mA} \\
\& \mathrm{~mA} \\
\& \mathrm{~mA}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
MATCHING CHARACTERISTICS \\
Dynamic \\
Crosstalk \\
Gain Flatness Match \\
DC \\
Input Offset Voltage \\
-Input Bias Current
\end{tabular} \& \[
\begin{aligned}
\& \mathrm{G}=+2, \mathrm{f}=5 \mathrm{MHz} \\
\& \mathrm{G}=+2, \mathrm{f}=40 \mathrm{MHz} \\
\& \\
\& \mathrm{~T}_{\mathrm{MIN}}-\mathrm{T}_{\mathrm{MAX}} \\
\& \mathrm{~T}_{\mathrm{MIN}}-\mathrm{T}_{\mathrm{MAX}}
\end{aligned}
\] \& \[
\begin{aligned}
\& \pm 5 \mathrm{~V}, \pm 15 \mathrm{~V} \\
\& \pm 15 \mathrm{~V} \\
\& \\
\& \pm 5 \mathrm{~V}, \pm 15 \mathrm{~V} \\
\& \pm 5 \mathrm{~V}, \pm 15 \mathrm{~V}
\end{aligned}
\] \& \& \[
\begin{aligned}
\& -65 \\
\& 0.1 \\
\& 0.5 \\
\& 2
\end{aligned}
\] \& \[
\begin{aligned}
\& 2.5 \\
\& 10
\end{aligned}
\] \& \begin{tabular}{l}
dB \\
dB \\
mV \\
\(\mu \mathrm{A}\)
\end{tabular} \\
\hline \begin{tabular}{l}
POWER SUPPLY \\
Operating Range \\
Quiescent Current \\
Quiescent Current, Powered Down \\
Power Supply Rejection Ratio Input Offset Voltage -Input Current \\
+Input Current
\end{tabular} \& \begin{tabular}{l}
Per Amplifier \\
\(\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}\) \\
Per Amplifier
\[
\mathrm{V}_{\mathrm{s}}= \pm 1.5 \mathrm{~V} \text { to } \pm 15 \mathrm{~V}
\]
\end{tabular} \& \[
\begin{aligned}
\& \pm 5 \mathrm{~V} \\
\& \pm 15 \mathrm{~V} \\
\& \pm 15 \mathrm{~V} \\
\& \pm 5 \mathrm{~V} \\
\& \pm 15 \mathrm{~V}
\end{aligned}
\] \& \(\pm 1.2\)

72 \& | 3.5 |
| :--- |
| 4.5 |
| 0.5 |
| 0.75 |
| 80 |
| 0.3 |
| 0.005 | \& \[

$$
\begin{aligned}
& \pm 18 \\
& 4.0 \\
& 5.5 \\
& 6.7 \\
& 0.6 \\
& 0.9 \\
& \\
& \\
& 0.7 \\
& 0.05
\end{aligned}
$$

\] \& | V |
| :--- |
| mA |
| mA |
| mA |
| mA |
| mA |
| dB |
| $\mu \mathrm{A} / \mathrm{V}$ |
| $\mu \mathrm{A} / \mathrm{V}$ | <br>


\hline | DISABLE CHARACTERISTICS |
| :--- |
| Off Isolation |
| Off Output Impedance |
| Channel-to-Channel |
| Isolation |
| Turn-On Time |
| Turn-Off Time | \& \[

$$
\begin{aligned}
& \mathrm{f}=5 \mathrm{MHz} \\
& \mathrm{G}=+1 \\
& 2 \text { or } 3 \mathrm{Channels} \\
& \text { Mux, } \mathrm{f}=5 \mathrm{MHz}
\end{aligned}
$$

\] \& \[

$$
\begin{aligned}
& \pm 5 \mathrm{~V}, \pm 15 \mathrm{~V} \\
& \pm 5 \mathrm{~V}, \pm 15 \mathrm{~V} \\
& \pm 5 \mathrm{~V}, \pm 15 \mathrm{~V} \\
& \pm 5 \mathrm{~V}, \pm 15 \mathrm{~V}
\end{aligned}
$$

\] \& \& \[

$$
\begin{aligned}
& -57 \\
& 12.5 \\
& -65 \\
& \\
& 100 \\
& 80
\end{aligned}
$$

\] \& \& | dB |
| :--- |
| pF |
| dB |
| ns |
| ns | <br>

\hline
\end{tabular}

## NOTES

${ }^{1}$ Slew rate measurement is based on $10 \%$ to $90 \%$ rise time in the specified closed-loop gain.
Specifications subject to change without notice.

AD813-SPECIFICATIONS
Single Supply (@ $\mathrm{I}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{R}_{\mathrm{L}}=150 \Omega$, unless otherwise noted)


| Model | Conditions | $\mathrm{V}_{\text {S }}$ | AD813A |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max |  |
| OUTPUT CHARACTERISTICS <br> Output Voltage Swing p-p <br> Output Current <br> Short Circuit Current | $\mathrm{R}_{\mathrm{L}}=150 \Omega, \mathrm{~T}_{\mathrm{MIN}}-\mathrm{T}_{\mathrm{MAX}}$ $\begin{aligned} & \mathrm{G}=+2, \mathrm{R}_{\mathrm{F}}=715 \Omega \\ & \mathrm{~V}_{\mathrm{IN}}=1 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & +5 \mathrm{~V} \\ & +3 \mathrm{~V} \\ & +5 \mathrm{~V} \\ & +3 \mathrm{~V} \\ & +5 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 3.0 \\ & 1.0 \\ & 20 \\ & 15 \end{aligned}$ | $\begin{aligned} & 3.2 \\ & 1.3 \\ & 30 \\ & 25 \\ & 40 \end{aligned}$ |  | $\begin{aligned} & \pm V p-p \\ & \pm V p-p \\ & m A \\ & m A \\ & m A \end{aligned}$ |
| MATCHING CHARACTERISTICS <br> Dynamic <br> Crosstalk <br> Gain Flatness Match <br> DC <br> Input Offset Voltage <br> -Input Bias Current | $\begin{aligned} & \mathrm{G}=+2, \mathrm{f}=5 \mathrm{MHz} \\ & \mathrm{G}=+2, \mathrm{f}=20 \mathrm{MHz} \\ & \\ & \mathrm{~T}_{\mathrm{MIN}}-\mathrm{T}_{\mathrm{MAX}} \\ & \mathrm{~T}_{\mathrm{MIN}}-\mathrm{T}_{\mathrm{MAX}} \end{aligned}$ | $\begin{aligned} & +5 \mathrm{~V},+3 \mathrm{~V} \\ & +5 \mathrm{~V},+3 \mathrm{~V} \\ & +5 \mathrm{~V},+3 \mathrm{~V} \\ & +5 \mathrm{~V},+3 \mathrm{~V} \end{aligned}$ |  | $\begin{aligned} & -65 \\ & 0.1 \\ & \\ & 0.5 \\ & 2 \end{aligned}$ | $\begin{aligned} & 2.5 \\ & 10 \end{aligned}$ | dB <br> dB <br> mV <br> $\mu \mathrm{A}$ |
| POWER SUPPLY <br> Operating Range <br> Quiescent Current <br> Quiescent Current, Powered Down <br> Power Supply Rejection Ratio Input Offset Voltage -Input Current <br> +Input Current | Per Amplifier <br> $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ <br> Per Amplifier $\mathrm{V}_{\mathrm{s}}=+3.0 \mathrm{~V} \text { to }+30 \mathrm{~V}$ | $\begin{aligned} & +5 \mathrm{~V} \\ & +3 \mathrm{~V} \\ & +5 \mathrm{~V} \\ & +5 \mathrm{~V} \\ & +3 \mathrm{~V} \end{aligned}$ | 2.4 | $\begin{aligned} & 3.2 \\ & 3.0 \\ & \\ & 0.4 \\ & 0.4 \\ & \\ & 76 \\ & 0.3 \\ & 0.005 \end{aligned}$ | $\begin{aligned} & 36 \\ & 4.0 \\ & 3.5 \\ & 5.0 \\ & 0.5 \\ & 0.5 \end{aligned}$ | V <br> mA <br> mA <br> mA <br> mA <br> mA <br> dB <br> $\mu \mathrm{A} / \mathrm{V}$ <br> $\mu \mathrm{A} / \mathrm{V}$ |
| DISABLE CHARACTERISTICS <br> Off Isolation <br> Off Output Impedance <br> Channel-to-Channel <br> Isolation <br> Turn-On Time <br> Turn-Off Time | $\begin{aligned} & \mathrm{f}=5 \mathrm{MHz} \\ & \mathrm{G}=+1 \\ & 2 \text { or } 3 \mathrm{Channel} \\ & \text { Mux, } \mathrm{f}=5 \mathrm{MHz} \end{aligned}$ | $\begin{aligned} & +5 \mathrm{~V},+3 \mathrm{~V} \\ & +5 \mathrm{~V},+3 \mathrm{~V} \\ & +5 \mathrm{~V},+3 \mathrm{~V} \\ & +5 \mathrm{~V},+3 \mathrm{~V} \end{aligned}$ |  | $\begin{aligned} & -55 \\ & 13 \\ & -65 \\ & \\ & 100 \\ & 80 \end{aligned}$ |  | dB pF dB <br> ns <br> ns |
| TRANSISTOR COUNT |  |  |  | 111 |  |  |

## NOTES

${ }^{1}$ Slew rate measurement is based on $10 \%$ to $90 \%$ rise time in the specified closed-loop gain.
${ }^{2}$ Single supply differential gain and phase are measured with the ac coupled circuit of Figure 49.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 18$ V
Internal Power Dissipation ${ }^{2}$
Plastic (N) . . . . . . . . . . . . . . . . . . . . . . 1.6 Watts
Small Outline (R) . . . . . . . . . . . . . . . . . 1.0 Watts
Input Voltage (Common Mode) . . . . . . . . . . . . . . . $\pm \mathrm{V}_{\mathrm{s}}$
Differential Input Voltage . . . . . . . . . . . . . . . . . . $\pm 6$ V
Output Short Circuit Duration . . . Observe Power Derating Curves
Storage Temperature Range N, R . . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Operating Temperature Range
AD813A . . . . . . . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Lead Temperature Range (Soldering 10 sec ) . . . . . . . . $+300^{\circ} \mathrm{C}$

NOTES
${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ Specification is for device in free air:
14-Pin Plastic DIP Package: $\theta_{\mathrm{IA}}=75^{\circ} \mathrm{C} /$ Watt
14-Pin SOIC Package: $\theta_{\mathrm{JA}}=120^{\circ} \mathrm{C} / \mathrm{Watt}$

## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Options |
| :--- | :--- | :--- | :--- |
| AD813AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 14-Pin Plastic DIP | $\mathrm{N}-14$ |
| AD813AR-14 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 14-Pin Plastic SOIC | R-14 |
| AD813A Chips | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Die Form |  |

[^140]
## Maximum Power Dissipation

The maximum power that can be safely dissipated by the AD813 is limited by the associated rise in junction temperature. The maximum safe junction temperature for the plastic encapsulated parts is determined by the glass transition temperature of the plastic, about $150^{\circ} \mathrm{C}$. Exceeding this limit temporarily may cause a shift in parametric performance due to a change in the stresses exerted on the die by the package. Exceeding a junction temperature of $175^{\circ} \mathrm{C}$ for an extended period can result in device failure.
While the AD813 is internally short circuit protected, this may not be enough to guarantee that the maximum junction temperature $\left(150^{\circ} \mathrm{C}\right)$ is not exceeded under all conditions. To ensure proper operation, it is important to observe the derating curves.
It must also be noted that in (noninverting) gain configurations (with low values of gain resistor), a high level of input overdrive can result in a large input error current, which may result in a significant power dissipation in the input stage. This power must be included when computing the junction temperature rise due to total internal power.


Maximum Power Dissipation vs. Ambient Temperature

## METALIZATION PHOTO

Dimensions shown in inches and (mm).


## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD813 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



Figure 1. Input Common-Mode Voltage Range vs. Supply Voltage


Figure 2. Output Voltage Swing vs. Supply


Figure 3. Output Voltage Swing vs. Load Resistance


Figure 4. Supply Current vs. Junction Temperature


Figure 5. Supply Current vs. Supply Voltage at Low Voltages


Figure 6. Input Bias Current vs. Junction Temperature


Figure 7. Input Offset Voltage vs. Junction Temperature


Figure 8. Short Circuit Current vs. Junction Temperature


Figure 9. Linear Output Current vs. Junction Temperature


Figure 10. Linear Output Current vs. Supply Voltage


Figure 11. Closed-Loop Output Resistance vs. Frequency


Figure 12. Output Resistance vs. Frequency, Disabled State


Figure 13. Input Current and Voltage Noise vs. Frequency


Figure 14. Common-Mode Rejection vs. Frequency


Figure 15. Power Supply Rejection vs. Frequency


Figure 16. Open-Loop Transimpedance vs. Frequency (Relative to $1 \Omega$ )


Figure 17. Harmonic Distortion vs. Frequency


Figure 18. Output Swing and Error vs. Settling Time


Figure 19. Slew Rate vs. Output Step Size


Figure 20. Large Signal Pulse Response, Gain $=+1$, $\left(R_{F}=750 \Omega, R_{L}=150 \Omega, V_{S}= \pm 5 \mathrm{~V}\right)$


Figure 21. Closed-Loop Gain and Phase vs. Frequency, $G=+1$


Figure 22. Maximum Slew Rate vs. Supply Voltage


Figure 23. Small Signal Pulse Response, Gain $=+1$, ( $R_{F}=750 \Omega, R_{L}=150 \Omega, V_{s}= \pm 5 \mathrm{~V}$ )


Figure 24. $-3 d B$ Bandwidth vs. Supply Voltage, $G=+1$


Figure 25. Large Signal Pulse Response, Gain $=+10$, $\left(R_{F}=357 \Omega, R_{L}=500 \Omega, V_{s}= \pm 15 \mathrm{~V}\right)$


Figure 26. Closed-Loop Gain and Phase vs. Frequency, $G=+10, R_{L}=150 \Omega$


Figure 27. $-3 d B$ Bandwidth vs. Supply Voltage, $G=+10, R_{L}=150 \Omega$


Figure 28. Small Signal Pulse Response, Gain $=+10$, $\left(R_{F}=357 \Omega, R_{L}=150 \Omega, V_{s}= \pm 5 \mathrm{~V}\right)$


Figure 29. Closed-Loop Gain and Phase vs. Frequency, $G=+10, R_{L}=1 \mathrm{k} \Omega$


Figure 30. $-3 d B$ Bandwidth vs. Supply Voltage $G=+10, R_{L}=1 \mathrm{k} \Omega$


Figure 31. Large Signal Pulse Response, Gain =-1,


Figure 32. Closed-Loop Gain and Phase vs. Frequency, $G=-1, R_{L}=150 \Omega$


Figure 33. $-3 d B$ Bandwidth vs. Supply Voltage, $G=-1$, $R_{L}=150 \Omega$


Figure 34. Small Signal Pulse Response, Gain $=-1$, $\left(R_{F}=750 \Omega, R_{L}=150 \Omega, V_{s}= \pm 5 \mathrm{~V}\right)$


Figure 35. Closed-Loop Gain and Phase vs. Frequency, $G=-10, R_{L}=1 \mathrm{k} \Omega$


Figure 36. $-3 d B$ Bandwidth vs. Supply Voltage, $G=-10, R_{L}=1 \mathrm{k} \Omega$

## General Consideration

The AD813 is a wide bandwidth, triple video amplifier that offers a high level of performance on less than 5.5 mA per amplifier of quiescent supply current. With its fast acting power down switch, it is designed to offer outstanding functionality and performance at closed-loop inverting or noninverting gains of one or greater.
Built on a low cost, complementary bipolar process, and achieving bandwidth in excess of 100 MHz , differential gain and phase errors of better than $0.1 \%$ and $0.1^{\circ}$ (into $150 \Omega$ ), and output current greater than 40 mA , the AD 813 is an exceptionally efficient video amplifier. Using a conventional current feedback architecture, its high performance is achieved through careful attention to design details.

## Choice of Feedback \& Gain Resistors

Because it is a current feedback amplifier, the closed-loop bandwidth of the AD813 depends on the value of the feedback resistor. The bandwidth also depends on the supply voltage. In addition, attenuation of the open-loop response when driving load resistors less than about $250 \Omega$ will also affect the bandwidth. Table I contains data showing typical bandwidths at different supply voltages for some useful closed-loop gains when driving a load of $150 \Omega$. (Bandwidths will be about $20 \%$ greater for load resistances above a few hundred ohms.)

Table I. -3 dB Bandwidth vs. Closed-Loop Gain and Feedback Resistor, ( $\mathrm{R}_{\mathrm{L}}=150 \Omega$ )

| $\mathbf{V}_{\mathbf{S}}(\mathbf{V})$ | Gain | $\mathbf{R}_{\mathbf{F}}(\Omega)$ | $\mathbf{B W}(\mathbf{M H z})$ |
| :--- | :--- | :--- | :--- |
| $\pm 15$ | +1 | 866 | 125 |
|  | +2 | 681 | 100 |
|  | +10 | 357 | 60 |
|  | -1 | 681 | 100 |
|  | -10 | 357 | 55 |
| $\pm 5$ | +1 | 750 | 75 |
|  | +2 | 649 | 65 |
|  | +10 | 649 | 40 |
|  | -1 | 154 | 70 |
|  | -10 | 715 | 60 |
| +5 | +1 | 154 | 50 |
|  | +2 | 619 | 30 |
|  | +10 | 154 | 50 |
|  | -1 | 681 | 30 |
| +3 | +10 | 619 | 50 |
|  | +2 | 154 | 40 |
|  | +10 | 619 | 25 |
|  | -1 | 154 | 40 |
|  | -10 |  | 20 |

The choice of feedback resistor is not critical unless it is important to maintain the widest, flattest frequency response. The resistors recommended in the table are those (metal film values) that will result in the widest 0.1 dB bandwidth. In those applications where the best control of the bandwidth is desired, $1 \%$ metal film resistors are adequate. Wider bandwidths can be attained by reducing the magnitude of the feedback resistor (at the expense of increased peaking), while peaking can be reduced by increasing the magnitude of the feedback resistor.

To estimate the -3 dB bandwidth for closed-loop gains or feedback resistors not listed in the above table, the following two pole model for the AD813 may be used:

$$
A_{C L}=\frac{G}{S^{2}\left[\frac{\left(R_{F}+G r_{I N}\right) C_{T}}{2 \pi f_{2}}\right]+S\left(R_{F}+G r_{I N}\right) C_{T}+1}
$$

Where: $\mathrm{A}_{\mathrm{CL}}=$ closed-loop gain from "transcapacitance"
G. $=1+R_{F} / R_{G}$
$\mathrm{r}_{\mathrm{iN}}=$ input resistance of the inverting input
$\mathrm{C}_{\mathrm{T}}=$ "transcapacitance," which forms the open-loop dominant pole with the transresistance
$\mathrm{R}_{\mathrm{F}}=$ feedback resistor
$\mathrm{R}_{\mathrm{G}}=$ gain resistor
$\mathrm{f}_{2}=$ frequency of second (nondominant) pole
$s=2 \pi j f$
Appropriate values for the model parameters at different supply voltages are listed in Table II. Reasonable approximations for these values at supply voltages not found in the table can be obtained by a simple linear interpolation between those tabulated values which 'bracket' the desired condition.

Table II. Two Pole Model Parameters at Various Supplies

| $\mathbf{V}_{\mathbf{S}}(\mathbf{V})$ | $\mathbf{r}_{\mathbf{I N}}(\Omega)$ | $\mathbf{C}_{\mathrm{T}}(\mathbf{p F})$ | $\mathbf{f}_{2}(\mathbf{M H z})$ |
| :--- | :--- | :--- | :--- |
| $\pm 15$ | 85 | 2.5 | 150 |
| $\pm 5$ | 90 | 3.8 | 125 |
| +5 | 105 | 4.8 | 105 |
| +3 | 115 | 5.5 | 95 |

As discussed in many amplifier and electronics textbooks (such as Roberge's Operational Amplifiers: Theory and Practice), the -3 dB bandwidth for the 2-pole model can be obtained as:
where.

$$
\begin{gathered}
f_{3}=f_{n}\left[1-2 d^{2}+\left(2-4 d^{2}+4 d^{4}\right)^{1 / 2}\right]^{1 / 2} \\
f_{n}=\left[\frac{f_{2}}{\left(R_{F}+G r_{I N}\right) C_{T}}\right]^{1 / 2}
\end{gathered}
$$

and:

$$
d=\frac{1}{2}\left[f_{2}\left(R_{F}+G r_{I N}\right) C_{T}\right]^{1 / 2}
$$

This model will predict -3 dB bandwidth within about $10 \%$ to $15 \%$ of the correct value when the load is $150 \Omega$. However, it is not accurate enough to predict either the phase behavior or the frequency response peaking of the AD813.

## AD813

## Printed Circuit Board Layout Guidelines

As with all wideband amplifiers, printed circuit board parasitics can affect the overall closed-loop performance. Most important for controlling the 0.1 dB bandwidth are stray capacitances at the output and inverting input nodes. Increasing the space between signal lines and ground plane will minimize the coupling. Also, signal lines connecting the feedback and gain resistors should be kept short enough that their associated inductance does not cause high frequency gain errors.

## Power Supply Bypassing

Adequate power supply bypassing can be very important when optimizing the performance of high speed circuits. Inductance in the supply leads can (for example) contribute to resonant circuits that produce peaking in the amplifier's response. In addition, if large current transients must be delivered to a load, then large (greater than $1 \mu \mathrm{~F}$ ) bypass capacitors are required to produce the best settling time and lowest distortion. Although $0.1 \mu \mathrm{~F}$ capacitors may be adequate in some applications, more elaborate bypassing is required in other cases.
When multiple bypass capacitors are connected in parallel, it is important to be sure that the capacitors themselves do not form resonant circuits. A small (say $5 \Omega$ ) resistor may be required in series with one of the capacitors to minimize this possibility.
As discussed below, power supply bypassing can have a significant impact on crosstalk performance.

## Achieving Low Crosstalk

Measured crosstalk from the output of Amplifier 2 to the input of Amplifier 1 of the AD813 is shown in Figure 37. All other crosstalk combinations, (from the output of one amplifier to the input of another), are a few dB better than this due to the additional distance between critical signal nodes.


Figure 37. Worst Case Crosstalk vs. Frequency

A carefully laid-out PC board should be able to achieve the level of crosstalk shown in the figure. The most significant contributors to difficulty in achieving low crosstalk are inadequate power supply bypassing, overlapped input and/or output signal paths, and capacitive coupling between critical nodes.
The bypass capacitors must be connected to the ground plane at a point close to and between the ground reference points for the loads. (The bypass of the negative power supply is particularly important in this regard.) This requires careful planning as there are three amplifiers in the package, and low impedance signal return paths must be provided for each load. (Using a parallel combination of $1 \mu \mathrm{~F}, 0.1 \mu \mathrm{~F}$, and $0.01 \mu \mathrm{~F}$ bypass capacitors will help to achieve optimal crosstalk.)

The input and output signal return paths (to the bypass caps) must also be kept from overlapping. Since ground connections are not of perfectly zero impedance, current in one ground return path can produce a voltage drop in another ground return path if they are allowed to overlap.
Electric field coupling external to (and across) the package can be reduced by arranging for a narrow strip of ground plane to be run between the pins (parallel to the pin rows). Doing this on both sides of the board can reduce the high frequency crosstalk by about 5 dB or 6 dB .

## Driving Capacitive Loads

When used with the appropriate output series resistor, any load capacitance can be driven without peaking or oscillation. In most cases, less than $50 \Omega$ is all that is needed to achieve an extremely flat frequency response. As illustrated in Figure 41, the AD813 can be very attractive for driving large capacitive loads. In this case, the AD813's high output short circuit current allows for a $150 \mathrm{~V} / \mu \mathrm{s}$ slew rate when driving a 510 pF capacitor.


Figure 38. Circuit for Driving a Capacitive Load


Figure 39. Response to a Small Load Capacitor at $V_{s}= \pm 5 \mathrm{~V}$


Figure 40. Response to a Large Load Capacitor at $V_{s}= \pm 15 \mathrm{~V}$


Figure 41. Circuit of Figure 38 Driving a 510 pF Load Capacitor, $V_{s}= \pm 15 \mathrm{~V}\left(R_{L}=1 \mathrm{k} \Omega, R_{F}=R_{G}=750 \Omega\right.$, $R_{s}=15 \Omega$ )

## Overload Recovery

There are three important overload conditions to consider. They are due to: input common-mode voltage overdrive, output voltage overdrive, and input current overdrive. When the amplifier is configured for low closed-loop gains, and the input common-mode voltage range is exceeded, the recovery time will be very fast, typically under 30 ns . When configured for a higher gain, and overloaded at the output, the recovery time will also be short. For example, in a gain of +10 , with 6 dB of input overdrive, the recovery time of the AD813 is about 25 ns (see Figure 42).


Figure 42. $6 d B$ Overload Recovery, $G=+10$, $\left(R_{L}=500 \Omega, R_{F}=357 \Omega, V_{s}= \pm 5 \mathrm{~V}\right)$

In the case of high gains with very high levels of input overdrive, a longer recovery time will occur. For example, if the input com-mon-mode voltage range is exceeded in the gain of +10 , the recovery time will be on the order of 100 ns . This is primarily due to current overloading of the input stage.

As noted in the warning under "Maximum Power Dissipation," a high level of input overdrive in a high noninverting gain circuit can result in a large current flow in the input stage. Though this current is internally limited to about 40 mA , its effect on the total power dissipation may be significant.

## AD813

## High Performance Video Line Driver

At a gain of +2 , the AD813 makes an excellent driver for a back terminated $75 \Omega$ video line. Low differential gain and phase errors and wide 0.1 dB bandwidth can be realized over a wide range of power supply voltage. Excellent gain and group delay matching are also attainable over the full operating supply voltage range.

Figures 47 and 48 show the worst case matching; the match between amplifiers 2 and 3 is typically much better than this.


Figure 43. A Video Line Driver Operating at a Gain of $+2\left(R_{F}=R_{G}\right.$ from Table I)


Figure 44. Closed-Loop Gain \& Phase vs. Frequency for the Line Driver


Figure 45. $-3 d B$ Bandwidth vs. Supply Voltage for Gain $=+2, R_{L}=150 \Omega$


Figure 46. Fine-Scale Gain (Normalized) vs. Frequency


Figure 47. Closed-Loop Gain Matching vs. Frequency


Figure 48. Group Delay and Group Delay Matching vs. Frequency, $G=+2, R_{L}=150 \Omega$

## Operation Using a Single Supply

The AD813 will operate with total supply voltages from 36 V down to 2.4 V . With proper biasing (see Figure 49) it can make an outstanding single supply video amplifier. Since the input and output voltage ranges extend to within 1 V of the supply rails, it will handle a 1.3 V peak-to-peak signal on a single 3.3 V supply, or a 3 V peak-to-peak signal on a single 5 V supply. The small signal 0.1 dB bandwidths will exceed 10 MHz in either case, and the large signal bandwidths will exceed 6 MHz .
The capacitively coupled cable driver in Figure 49 will achieve outstanding differential gain and phase errors of $0.05 \%$ and 0.05 degrees respectively on a single 5 V supply. Resistor R2, in this circuit, is selected to optimize the differential gain and phase by biasing the amplifier in its most linear region.


Figure 49. Biasing for Single Supply Operation


Figure 50. Closed-Loop Gain and Phase vs. Frequency, Circuit of Figure 49


Figure 51. Pulse Response for the Circuit of Figure 49 with $+V_{s}=5 V$

## Disable Mode Operation

Pulling the voltage on any one of the Disable pins about 2.5 V down from the positive supply will put the corresponding amplifier into a disabled, powered down, state. In this condition, the amplifier's quiescent supply current drops to about 0.5 mA , its output becomes a high impedance, and there is a high level of isolation from input to output. In the case of the gain of two line driver for example, the impedance at the output node will be about the same as for a $1.4 \mathrm{k} \Omega$ resistor (the feedback plus gain resistors) in parallel with a 12.5 pF capacitor and the input to output isolation will be about 65 dB at 1 MHz .
Leaving the Disable pin disconnected (floating) will leave the corresponding amplifier operational, in the enabled state. The input impedance of the disable pins is about $35 \mathrm{k} \Omega$ in parallel with a few pF . When grounded, about $50 \mu \mathrm{~A}$ flows out of a disable pin on $\pm 5 \mathrm{~V}$ supplies.
Input voltages greater than about 1.5 V peak-to-peak will defeat the isolation. In addition, large signals (greater than 3 V peak-to-peak) applied to the output node will cause the output impedance to drop significantly.
When the Disable pins are driven by complementary output CMOS logic (such as the 74 HC 04 ), the disable time is about 80 ns (until the output goes high impedance) and the enable time is about 100 ns (to low impedance output) on $\pm 15 \mathrm{~V}$ supplies. When operated on $\pm 15 \mathrm{~V}$ supplies, the disable pins should be driven by open drain logic. In this case, pull-up resistors from the disable pins to the plus supply will ensure minimum switching time.

Figure 52. A Fast Switching 3:1 Video Mux (Supply Bypassing Not Shown)


## AD813

## 3:1 Video Multiplexer

Wiring the amplifier outputs together will form a $3: 1$ mux with outstanding gain flatness. Figure 52 shows a recommended configuration which results in -0.1 dB bandwidth of 20 MHz and OFF channel isolation of 60 dB at 10 MHz on $\pm 5 \mathrm{~V}$ supplies. The time to switch between channels is about 180 ns . Switching time is only slightly affected by signal level.


Figure 53. Channel Switching Characteristic for the 3:1 Mux


Figure 54. 3:1 Mux OFF Channel Feedthrough vs. Frequency


Figure 55. 3:1 Mux ON Channel Gain and Phase vs. Frequency

## Single Supply Differential Line Driver

Due to its outstanding overall performance on low supply voltages, the AD813 makes possible exceptional differential transmission on very low power. The circuit of Figure 56 will convert a singleended, ground referenced signal to a differential signal whose common-mode reference is set to one half the supply voltage. This allows for a greater than 2 V peak-to-peak signal swing on a single 3 V power supply. A bandwidth over 30 MHz is achieved with 20 mA of output drive on only 30 mW of quiescent power (excluding load current).


Figure 56. Single 3 V Supply Differential Line Driver with $2 V$ Swing


Figure 57. Differential Driver Pulse Response $\left(V_{s}=3 V\right.$, $R_{L 1}=R_{L 2}=200 \Omega$ )

## FEATURES

Low Cost
High Speed
50 MHz Unity Gain Bandwidth
350 V/ $\mu$ s Slew Rate
45 ns Settling Time to $0.1 \%$ ( 10 V Step)
Flexible Power Supply
Specified for Single (+5 V) and Dual ( $\pm 5 \mathrm{~V}$ to $\pm 15$ V) Power Supplies
Low Power: 7.5 mA max Supply Current
High Output Drive Capability
Drives Unlimited Capacitive Load
50 mA Minimum Output Current
Excellent Video Performance
70 MHz 0.1 dB Bandwidth (Gain $=+1$ )
$0.04 \%$ \& $0.08^{\circ}$ Differential Gain \& Phase Errors @ 3.58 MHz
Available in 8-Pin SOIC and 8-Pin Plastic Mini-DIP

## PRODUCT DESCRIPTION

The AD817 is a low cost, low power, single/dual supply, high speed op amp which is ideally suited for a broad spectrum of signal conditioning and data acquisition applications. This breakthrough product also features high output current drive capability and the ability to drive an unlimited capacitive load while still maintaining excellent signal integrity.

The 50 MHz unity gain bandwidth, $350 \mathrm{~V} / \mu$ s slew rate and settling time of $45 \mathrm{~ns}(0.1 \%)$ make possible the processing of high speed signals common to video and imaging systems. Furthermore, professional video performance is attained by offering differential gain \& phase errors of $0.04 \%$ \& $0.08^{\circ} @ 3.58 \mathrm{MHz}$ and 0.1 dB flatness to 70 MHz (gain $=+1$ ).


CONNECTION DIAGRAM
8-Pin Plastic Mini-DIP (N), and
SOIC (R) Packages


The AD817 is fully specified for operation with a single +5 V power supply and with dual supplies from $\pm 5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$. This power supply flexibility, coupled with a very low supply current of 7.5 mA and excellent ac characteristics under all power supply conditions, make the AD817 the ideal choice for many demanding yet power sensitive applications.
In applications such as ADC buffers and line drivers the AD817 simplifies the design task with its unique combination of a 50 mA minimum output current and the ability to drive unlimited capacitive loads.
The AD817 is available in 8-pin plastic mini-DIP and SOIC packages.


AD817 Driving a Large Capacitive Load



|  |  |  | AD817A <br> Parameter |  | Conditions |
| :--- | :--- | :--- | :--- | :--- | :--- |

NOTE
${ }^{1}$ Full power bandwidth $=$ slew rate $/ 2 \pi \mathrm{~V}_{\text {PEAK }}$.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 18$ V Internal Power Dissipation ${ }^{2}$

Plastic (N) . . . . . . . . . . . . . . . . . . . See Derating Curves
Small Outline (R) . . . . . . . . . . . . . . See Derating Curves
Input Voltage (Common Mode) . . . . . . . . . . . . . . . . . $\pm \mathrm{V}_{\mathrm{S}}$
Differential Input Voltage . . . . . . . . . . . . . . . . . . . . $\pm 6$ V
Output Short Circuit Duration . . . . . . . . See Derating Curves
Storage Temperature Range (N, R) . . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Operating Temperature Range . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Lead Temperature Range (Soldering 10 seconds) . . . . $+300^{\circ} \mathrm{C}$
NOTES
${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ Specification is for device in free air: 8-pin plastic package, $\theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} /$ watt; 8 -pin SOIC package, $\theta_{\mathrm{JA}}=155^{\circ} \mathrm{C} /$ watt.

## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD817AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | N-8 |
| AD817AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | R-8 |

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AMBIENT TEMPERATURE - ${ }^{\circ} \mathrm{C}$
Maximum Power Dissipation vs. Temperature for Different Package Types

## ESD SUSCEPTIBILITY

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 volts, which readily accumulate on the human body and on test equipment, can discharge without detection. Although the AD817 features proprietary ESD protection circuitry, permanent damage may still occur on these . devices if they are subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid any performance degradation or loss of functionality.

## AD817—Typical Characteristics



Figure 1. Common-Mode Voltage Range vs. Supply


Figure 2. Output Voltage Swing vs. Supply


Figure 3. Output Voltage Swing vs. Load Resistance


Figure 4. Quiescent Supply Current vs. Supply Voltage for Various Temperatures


Figure 5. Slew Rate vs. Supply Voltage


Figure 6. Closed-Loop Output Impedance vs. Frequency


Figure 7. Input Bias Current vs. Temperature


Figure 8. Short Circuit Current vs. Temperature


Figure 9. Unity Gain Bandwidth and Phase Margin vs. Temperature


Figure 10. Open-Loop Gain and Phase Margin vs. Frequency


Figure 11. Open Loop Gain vs. Load Resistance


Figure 12. Power Supply Rejection vs. Frequency

## AD817 - Typical Characteristics



Figure 13. Common-Mode Rejection vs. Frequency


Figure 14. Large Signal Frequency Response


Figure 15. Output Swing and Error vs. Settling Time


Figure 16. Harmonic Distortion vs. Frequency


Figure 17. Input Voltage Noise Spectral Density


Figure 18. Slew Rate vs. Temperature


Figure 19. Differential Gain and Phase vs. Supply Voltage


Figure 20. Closed-Loop Gain vs. Frequency, Gain $=-1$


Figure 21. Closed-Loop Gain vs. Frequency, Gain $=+1$


Figure 22. Noninverting Amplifier Connection

## AD817—Typical Characteristics



Figure 23. Noninverting Large Signal Pulse Response, $R_{L}=1 \mathrm{k} \Omega$


Figure 24. Noninverting Small Signal Pulse Response, $R_{L}=1 \mathrm{k} \Omega$


Figure 25. Noninverting Large Signal Pulse Response, $R_{L}=150 \Omega$


Figure 26. Noninverting Small Signal Pulse Response, $R_{L}=150 \Omega$


Figure 27. Inverting Amplifier Connection


Figure 29. Inverting Small Signal Pulse Response, $R_{L}=1 \mathrm{k} \Omega$


Figure 28. Inverting Large Signal Pulse Response, $R_{L}=1 \mathrm{k} \Omega$


Figure 30a. Inverting Amplifier Driving a 1000 pF Capacitive Load

## DRIVING CAPACITIVE LOADS

The internal compensation of the AD817, together with its high output current drive, permit excellent large signal performance while driving extremely high capacitive loads.


Figure 30b. Inverting Amplifier Pulse Response While Driving Capacitive Loads


Figure 31. Simplified Schematic

## THEORY OF OPERATION

The AD817 is a low cost, wide band, high performance operational amplifier which effectively drives heavy capacitive or resistive loads. It also provides a constant slew rate, bandwidth and settling time over its entire specified temperature range.

The AD817 (Figure 31) consists of a degenerated NPN differential pair driving matched PNPs in a folded-cascode gain stage. The output buffer stage employs emitter followers in a class AB amplifier which delivers the necessary current to the load while maintaining low levels of distortion.
The capacitor, $\mathrm{C}_{\mathrm{F}}$, in the output stage mitigates the effect of capacitive loads. At low frequencies, and with low capacitive loads, the gain from the compensation node to the output is very close to unity. In this case, $\mathrm{C}_{\mathrm{F}}$ is bootstrapped and does not contribute to the overall compensation capacitance of the device. As the capacitive load is increased, a pole is formed with the output impedance of the output stage. This reduces the gain, and therefore, $\mathrm{C}_{\mathrm{F}}$ is incompletely bootstrapped. Effectively, some fraction of $\mathrm{C}_{\mathrm{F}}$ contributes to the overall compensation capacitance, reducing the unity gain bandwidth. As the load capacitance is further increased, the bandwidth continues to fall, maintaining the stability of the amplifier.

## INPUT CONSIDERATIONS

An input protection resistor ( $\mathrm{R}_{\mathrm{IN}}$ in Figure 22) is required in circuits where the input to the AD817 will be subjected to transient or continuous overload voltages exceeding the +6 V maximum differential limit. This resistor provides protection for the input transistors by limiting their maximum base current.

For high performance circuits, it is recommended that a "balancing" resistor be used to reduce the offset errors caused by bias current flowing through the input and feedback resistors. The balancing resistor equals the parallel combination of $\mathrm{R}_{\text {IN }}$ and $\mathrm{R}_{\mathrm{F}}$ and thus provides a matched impedance at each input terminal. The offset voltage error will then be reduced by more than an order of magnitude.

## GROUNDING \& BYPASSING

When designing high frequency circuits, some special precautions are in order. Circuits must be built with short interconnect leads. When wiring components, care should be taken to provide a low resistance, low inductance path to ground. Sockets should be avoided, since their increased interlead capacitance can degrade circuit bandwidth.
Feedback resistors should be of low enough value ( $<1 \mathrm{k} \Omega$ ) to assure that the time constant formed with the inherent stray capacitance at the amplifier's summing junction will not limit performance. This parasitic capacitance, along with the parallel resistance of $\mathrm{R}_{\mathrm{F}} / \mathrm{R}_{\mathrm{IN}}$, form a pole in the loop transmission which may result in peaking. A small capacitance ( $1-5 \mathrm{pF}$ ) may be used in parallel with the feedback resistor to neutralize this effect.

Power supply leads should be bypassed to ground as close as possible to the amplifier pins. Ceramic disc capacitors of $0.1 \mu \mathrm{~F}$ are recommended.


Figure 32. Offset Null Configuration

## OFFSET NULLING

The input offset voltage of the AD817 is inherently very low. However, if additional nulling is required, the circuit shown in Figure 32 can be used. The null range of the AD817 in this configuration is $\pm 15 \mathrm{mV}$.

## AD817 SETTLING TIME

Settling time is comprised primarily of two regions. The first is the slew time in which the amplifier is overdriven, where the output voltage rate of change is at its maximum. The second is the linear time period required for the amplifier to settle to within a specified percent of the final value.
Measuring the rapid settling time of AD817 ( 45 ns to $0.1 \%$ and 70 ns to $0.01 \%-10 \mathrm{~V}$ step) requires applying an input pulse
with a very fast edge and an extremely flat top. With the AD817 configured in a gain of -1 , a clamped false summing junction responds when the output error is within the sum of two diode voltages ( $\approx 1$ volt). The signal is then amplified 20 times by a clamped amplifier whose output is connected directly to a sampling oscilloscope. Figures 33 and 34 show the settling time of the AD817, with a 10 volt step applied.


Figure 33. Settling Time in ns 0 V to +10 V


Figure 34. Settling Time in ns 0 V to -10 V


Figure 35. Settling Time Test Circuit


Figure 36. A Differential Input Buffer for High Bandwidth ADCs

## A HIGH PERFORMANCE ADC INPUT BUFFER

High performance analog to digital converters (ADCs) require input buffers with correspondingly high bandwidths and very low levels of distortion. Typical requirements include distortion levels of -60 dB to -70 dB for a 1 volt $\mathrm{p}-\mathrm{p}$ signal and bandwidths of 10 MHz or more. In addition, an ADC buffer may need to drive very large capacitive loads.
The circuit of Figure 36 is useful for driving high speed converters such as the differential input of the AD733, 10-bit ADC. This circuit may be used with other converters with only minor modifications. Using the AD817 provides the user with the option of either operating the buffer in differential mode or from a single +5 volt supply. Operating from a +5 volt power supply helps to avoid overdriving the ADC - a common problem with buffers operating at higher supply voltages.

## SINGLE SUPPLY OPERATION

Another exciting feature of the AD817 is its ability to perform well in a single supply configuration. The AD817 is ideally suited for applications that require low power dissipation and high output current and those which need to drive large capacitive loads, such as high speed buffering and instrumentation.

Referring to Figure 37, careful consideration should be given to the proper selection of component values. The choices for this particular circuit are: $\mathrm{R} 1+\mathrm{R} 3 / / \mathrm{R} 2$ combine with C 1 to form a low frequency corner of approximately 300 Hz .


Figure 37. Single Supply Amplifier Configuration
Combining R3 with C 2 forms a low-pass filter with a corner frequency of 1.5 kHz . This is needed to maintain amplifier PSRR, since the supply is connected to $\mathrm{V}_{\text {IN }}$ through the input divider. The values for $R_{L}$ and $C_{L}$ were chosen to demonstrate the AD817's exceptional output drive capability. In this configuration, the output is centered around 2.5 V . In order to eliminate the static dc current associated with this level, C3 was inserted in series with $\mathbf{R}_{\mathbf{L}}$.

## HIGH SPEED DAC BUFFER

The wide bandwidth and fast settling time of the AD817 make it a very good output buffer for high speed current-output D/A converters like the AD668. As shown in Figure 38, the op amp establishes a summing node at ground for the DAC output. The output voltage is determined by the amplifier's feedback resistor
( 10.24 V for a $1 \mathrm{k} \Omega$ resistor). Note that since the DAC generates a positive current to ground, the voltage at the amplifier output will be negative. A $100 \Omega$ series resistor between the noninverting amplifier input and ground minimizes the offset effects of op amp input bias currents.


Figure 38. High Speed DAC Buffer

## FEATURES

Low Cost
Excellent Video Performance
55 MHz 0.1 dB Bandwidth (Gain $=+2$ )
$0.01 \%$ \& $0.05^{\circ}$ Differential Gain \& Phase Errors
High Speed
130 MHz Bandwidth ( $3 \mathrm{~dB}, \mathrm{G}=+2$ )
100 MHz Bandwidth ( $3 \mathrm{~dB}, \mathrm{G}+=-1$ )
500 V/ $\mu \mathrm{s}$ Slew Rate
80 ns Settling Time to $\mathbf{0 . 0 1 \%}$ ( $\mathrm{V}_{\mathrm{O}}=10 \mathrm{~V}$ Step)
High Output Drive Capability
50 mA Minimum Output Current
Ideal for Driving Back Terminated Cables
Flexible Power Supply
Specified for Single ( +5 V ) and Dual ( $\pm 5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$ ) Power Supplies
Low Power: 7.5 mA max Supply Current
Available in 8-Pin SOIC and 8-Pin Plastic Mini-DIP

## PRODUCT DESCRIPTION

The AD818 is a low cost, video op amp optimized for use in video applications which require gains equal to or greater than +2 or -1 . The AD818 low differential gain and phase errors, single supply functionality, low power and high output drive make it ideal for cable driving applications such as video cameras and professional video equipment.
With video specs like 0.1 dB flatness to 55 MHz and low differential gain and phase errors of $0.01 \%$ and $0.05^{\circ}$, along with 50 mA of output current, the AD818 is an excellent choice for any video application. The 130 MHz 3 dB bandwidth ( $\mathrm{G}=+2$ )


AD818 Video Line Driver

CONNECTION DIAGRAMS
8-Pin Plastic Mini-DIP (N), and SOIC (R) Packages


NC = NO CONNECT
and $500 \mathrm{~V} / \mu \mathrm{s}$ slew rate make the AD818 useful in many high speed applications including: video monitors, CATV, color copiers, image scanners and fax machines.
The AD818 is fully specified for operation with a single +5 V power supply and with dual supplies from $\pm 5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$. This power supply flexibility, coupled with a very low supply current of 7.5 mA and excellent ac characteristics under all power supply conditions, make the AD818 the ideal choice for many demanding yet power sensitive applications.

The AD818 is a voltage feedback op amp and excels as a gain stage in high speed and video systems (gain $=>2$ or -1 ). It achieves a settling time of 45 ns to $0.1 \%$, with a low input offset voltage of 2 mV max.
The AD818 is available in low cost, small 8-pin plastic miniDIP and SOIC packages.


AD818 Differential Gain and Phase vs. Supply
(@ $T_{A}=+25^{\circ} C$, unless otherwise noted)


| Parameter |  |  | AD818A |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Conditions | $\mathbf{V}_{\mathbf{s}}$ | Min | Typ | Max |  |
| INPUT COMMON-MODE VOLTAGE RANGE |  | $\begin{aligned} & \pm 5 \mathrm{~V} \\ & \pm 15 \mathrm{~V} \\ & 0,+5 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & +3.8 \\ & -2.7 \\ & +13 \\ & -12 \\ & +3.8 \\ & +1.2 \end{aligned}$ | $\begin{aligned} & +4.3 \\ & -3.4 \\ & +14.3 \\ & -13.4 \\ & +4.3 \\ & +0.9 \end{aligned}$ |  | $\begin{aligned} & \mathbf{V} \\ & \mathbf{V} \\ & \mathbf{V} \\ & \mathbf{V} \\ & \mathbf{V} \\ & \mathbf{V} \end{aligned}$ |
| OUTPUT VOLTAGE SWING Output Current Short-Circuit Current | $\begin{aligned} & \mathbf{R}_{\text {LOAD }}=500 \Omega \\ & \mathbf{R}_{\text {LOAD }}=150 \Omega \\ & \mathbf{R}_{\text {LOAD }}=1 \mathrm{k} \Omega \\ & \mathbf{R}_{\text {LOAD }}=500 \Omega \\ & \mathbf{R}_{\text {LOAD }}=500 \Omega \end{aligned}$ | $\begin{aligned} & \pm 5 \mathrm{~V} \\ & \pm 5 \mathrm{~V} \\ & \pm 15 \mathrm{~V} \\ & \pm 15 \mathrm{~V} \\ & 0,+5 \mathrm{~V} \\ & \\ & \pm 15 \mathrm{~V} \\ & \pm 5 \mathrm{~V} \\ & 0,+5 \mathrm{~V} \\ & \pm 15 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 3.3 \\ & 3.2 \\ & 13.3 \\ & 12.8 \\ & +1.5, \\ & +3.5 \\ & 50 \\ & 50 \\ & 30 \end{aligned}$ | 3.8 <br> 3.6 <br> 13.7 <br> 13.4 <br> 90 |  | $\begin{aligned} & \pm \mathrm{V} \\ & \pm \mathrm{V} \\ & \pm \mathrm{V} \\ & \pm \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~mA} \\ & \mathrm{~mA} \\ & \mathrm{~mA} \\ & \mathrm{~mA} \end{aligned}$ |
| INPUT RESISTANCE |  |  |  | 300 |  | $\mathrm{k} \Omega$ |
| INPUT CAPACITANCE |  |  |  | 1.5 |  | pF |
| OUTPUT RESISTANCE | Open Loop |  |  | 8 |  | $\Omega$ |
| POWER SUPPLY <br> Operating Range <br> Quiescent Current | Dual Supply Single Supply <br> $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ <br> $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ | $\begin{aligned} & \pm 5 \mathrm{~V} \\ & \pm 5 \mathrm{~V} \\ & \pm 15 \mathrm{~V} \\ & \pm 15 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & \pm 2.5 \\ & +5 \end{aligned}$ | $\begin{aligned} & 7.0 \\ & 7.0 \end{aligned}$ | $\begin{aligned} & \pm 18 \\ & +36 \\ & 7.5 \\ & 7.5 \\ & 7.5 \\ & 7.5 \end{aligned}$ | V V mA mA mA mA |

## NOTE

${ }^{1}$ Full power bandwidth $=$ slew rate $/ 2 \pi V_{\text {Peak }}$.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

Supply Voltage
Internal Power Dissipation ${ }^{2}$
Plastic (N) . . . . . . . . . . . . . . . . . . . See Derating Curves
Small Outline (R) . . . . . . . . . . . . . . See Derating Curves Input Voltage (Common Mode) . . . . . . . . . . . . . . . . . $\pm \mathrm{V}_{\mathrm{S}}$ Differential Input Voltage . . . . . . . . . . . . . . . . . . . . $\pm 6$ V Output Short Circuit Duration . . . . . . . . See Derating Curves Storage Temperature Range (N, R) . . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ Operating Temperature Range . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ Lead Temperature Range (Soldering 10 seconds) . . . . $+300^{\circ} \mathrm{C}$ NOTES
${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ Specification is for device in free air: 8 -pin plastic package, $\theta_{\mathrm{JA}}=90^{\circ} \mathrm{C} / \mathrm{watt}$; 8 -pin SOIC package, $\theta_{\mathrm{JA}}=155^{\circ} \mathrm{C} /$ watt.

## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD818AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | N-8 |
| AD818AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | R-8 |
| AD818AR-REEL | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | R-8 |

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## Maximum Power Dissipation vs. Temperature for Different Package Types

## ESD SUSCEPTIBILITY

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 volts, which readily accumulate on the human body and on test equipment, can discharge without detection. Although the AD817 features proprietary ESD protection circuitry, permanent damage may still occur on these devices if they are subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid any performance degradation or loss of functionality.

METALIZATION PHOTOGRAPH



Figure 1. Common-Mode Voltage Range vs. Supply


Figure 2. Output Voltage Swing vs. Load Resistance


Figure 3. Slew Rate vs. Supply Voltage


Figure 4. Output Voltage Swing vs. Supply

## AD818 - Typical Characteristics



Figure 5. Quiescent Supply Current vs. Supplý Voltage


Figure 6. Closed-Loop Output Impedance vs. Frequency


Figure 7. Input Bias Current vs. Temperature


Figure 8. $-3 d B$ Bandwidth and Phase Margin vs. Temperature. Gain $=+2$


Figure 9. Open-Loop Gain vs. Load Resistance


Figure 10. Short Circuit Current vs. Temperature


Figure 11. Open-Loop Gain and Phase Margin vs. Frequency


Figure 12. Power Supply Rejection vs. Frequency


Figure 13. Common-Mode Rejection vs. Frequency


Figure 14. Output Swing and Error vs. Settling Time


Figure 15. Input Voltage Noise Spectral Density vs. Frequency


Figure 16. Output Voltage vs. Frequency

## AD818-Typical Characteristics



Figure 17. Harmonic Distortion vs. Frequency


Figure 18. Slew Rate vs. Temperature


Figure 19. Differential Gain and Phase vs. Supply Voltage


Figure 20. Closed-Loop Gain vs. Frequency $(G=+2)$


Figure 21. Closed-Loop Gain vs. Frequency ( $G=-1$ )


Figure 22. Inverting Amplifier Connection


Figure 23. Inverter Large Signal Pulse Response $\pm 5 V_{S}$, $C_{F}=1 \mathrm{pF}, R_{L}=1 \mathrm{k} \Omega$


Figure 24. Inverter Small Signal Pulse Response $\pm 5 V_{S}$, $C_{F}=1 \mathrm{pF}, R_{L}=150 \Omega$


Figure 25. Inverter Large Signal Pulse Response $\pm 15 V_{S}$, $C_{F}=1 \mathrm{pF}, R_{L}=1 \mathrm{k} \Omega$


Figure 26. Inverter Small Signal Pulse Response $\pm 15 \mathrm{~V}_{S}$, $C_{F}=1 \mathrm{pF}, R_{\mathrm{L}}=150 \Omega$


Figure 27. Inverter Small Signal Pulse Response $\pm 5 V_{S}$, $C_{F}=0 p F, R_{L}=150 \Omega$

## AD818 - Typical Characteristics



Figure 28. Noninverting Amplifier Connection


Figure 29. Noninverting Large Signal Pulse Response $\pm 5 \mathrm{~V}, C_{F}=1 \mathrm{pF}, R_{\mathrm{L}}=1 \mathrm{k} \Omega$


Figure 30. Noninverting Small Signal Pulse Response $\pm 5 \mathrm{~V}, C_{F}=1 \mathrm{pF}, R_{L}=150 \Omega$


Figure 31. Noninverting Large Signal Pulse Response $\pm 15 \mathrm{~V}, C_{F}=1 \mathrm{pF}, R_{L}=1 \mathrm{k} \Omega$


Figure 32. Noninverting Small Signal Pulse Response $\pm 15 \mathrm{~V}, C_{F}=1 \mathrm{pF}, R_{L}=150 \Omega$


Figure 33. Noninverting Small Signal Pulse Response $\pm 5 \mathrm{~V}, C_{F}=0 \mathrm{pF}, R_{L}=150 \Omega$


Figure 34. AD818 Simplified Schematic

## THEORY OF OPERATION

The AD818 is a low cost, video operational amplifier designed to excel in high performance, high output current video applications.
The AD818 (Figure 34) consists of a degenerated NPN differential pair driving matched PNPs in a folded-cascode gain stage.
The output buffer stage employs emitter followers in a class AB amplifier which delivers the necessary current to the load, while maintaining low levels of distortion.
The AD818 will drive terminated cables and capacitive loads of 10 pF or less. As the closed-loop gain is increased, the AD818 will drive heavier cap loads without oscillating.

## INPUT CONSIDERATIONS

An input protection resistor ( $\mathrm{R}_{\mathrm{IN}}$ in Figure 28) is required in circuits where the input to the AD818 will be subjected to transient of continuous overload voltages exceeding the $\pm 6 \mathrm{~V}$ maximum differential limit. This resistor provides protection for the input transistors by limiting their maximum base current.
For high performance circuits, it is recommended that a "balancing" resistor be used to reduce the offset errors caused by bias current flowing through the input and feedback resistors. The balancing resistor equals the parallel combination of $\mathrm{R}_{\mathrm{IN}}$ and $\mathrm{R}_{\mathrm{F}}$ and thus provides a matched impedance at each input terminal. The offset voltage error will then be reduced by more than an order of magnitude.

## GROUNDING AND BYPASSING

When designing high frequency circuits, some special precautions are in order. Circuits must be built with short interconnect leads. When wiring components, care should be taken to provide a low resistance, low inductance path to ground. Sockets should be avoided, since their increased interlead capacitance can degrade circuit bandwidth.
Feedback resistors should be of low enough value ( $\leq 1 \mathrm{k} \Omega$ ) to assure that the time constant formed with the inherent stray capacitance at the amplifier's summing junction will not limit performance. This parasitic capacitance, along with the parallel resistance of $R_{F} / R_{I N}$, form a pole in the loop transmission which
may result in peaking. A small capacitance ( $1-5 \mathrm{pF}$ ) may be used in parallel with the feedback resistor to neutralize this effect.

Power supply leads should be bypassed to ground as close as possible to the amplifier pins. Ceramic disc capacitors of $0.1 \mu \mathrm{~F}$ are recommended.


Figure 35. Offset Null Configuration

## OFFSET NULLING

The input offset voltage of the AD818 is inherently very low. However, if additional nulling is required, the circuit shown in Figure 35 can be used. The null range of the AD818 in this configuration is $\pm 10 \mathrm{mV}$.

## SINGLE SUPPLY OPERATION

Another exciting feature of the AD818 is its ability to perform well in a single supply configuration. The AD818 is ideally suited for applications that require low power dissipation and high output current.

Referring to Figure 36, careful consideration should be given to the proper selection of component values. The choices for this particular circuit are: $\mathrm{R} 1+\mathrm{R} 3 \| \mathrm{R} 2$ combine with C 1 to form a low frequency corner of approximately 10 kHz . C4 was inserted in series with R4 to maintain amplifier stability at high frequency.
Combining R3 with C2 forms a low pass filter with a corner frequency of approximately 500 Hz . This is needed to maintain amplifier PSRR, since the supply is connected to $\mathrm{V}_{\text {IN }}$ through the input divider. The values for R2 and C2 were chosen to demonstrate the AD818's exceptional output drive capability. In this configuration, the output is centered around 2.5 V . In order to eliminate the static dc current associated with this level, C3 was inserted in series with $\mathbf{R}_{\mathbf{L}}$.


Figure 36. Single Supply Amplifier Configuration


Figure 37. Settling Time Test Circuit

## AD818 SETTLING TIME

Settling time is comprised primarily of two regions. The first is the slew time in which the amplifier is overdriven, where the output voltage rate of change is at its maximum. The second is the linear time period required for the amplifier to settle to within a specified percent of the final value.
Measuring the rapid settling time of AD818 ( 45 ns to $0.1 \%$ and 80 ns to $0.01 \%-10 \mathrm{~V}$ step) requires applying an input pulse with a very fast edge and an extremely flat top. With the AD818 configured in a gain of -1 , a clamped false summing junction responds when the output error is within the sum of two diode voltages (approximately 1 volt). The signal is then amplified 20 times by a clamped amplifier whose output is connected directly to a sampling oscilloscope.

## A High Performance Video Line Driver

The buffer circuit shown in Figure 38 will drive a backterminated $75 \Omega$ video line to standard video levels ( 1 V p-p) with 0.1 dB gain flatness to 55 MHz with only $0.05^{\circ}$ and $0.01 \%$ differential phase and gain at the 3.58 MHz NTSC subcarrier frequency. This level of performance, which meets the requirements for high-definition video displays and test equipment, is achieved using only 7 mA quiescent current.


Figure 38. Video Line Driver

## DIFFERENTIAL LINE RECEIVER

The differential receiver circuit of Figure 39 is useful for many applications from audio to video. It allows extraction of a low level signal in the presence of common-mode noise. As shown in Figure 40, the AD818 provides this function with only $10 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ noise at the output.


Figure 39. Differential Line Receiver


Figure 40. Performance of Line Receiver, $R_{L}=150 \Omega$, $G=+2$

## A HIGH SPEED, THREE OP AMP IN AMP

The circuit of Figure 41 uses three high speed op amps: two AD818s and an AD817. This high speed circuit lends itself well to CCD imaging and other video speed applications. It has the optional flexibility of both dc and ac trims for common-mode rejection, plus the ability to adjust for minimum settling time.


BANDWIDTH, SETTLING TIME, \& TOTAL HARMONIC DISTORTION VS. GAIN

|  |  | CADJ <br> (PF) | SMALL <br> SIGNAL <br> BANDWIDTH | SETTLING <br> TIME <br> TO $0.1 \%$ | THD + NOISE <br> BELOW <br> @ 10kHz |
| :--- | :--- | :--- | :--- | :--- | :--- |
| 3 | R $_{\mathbf{G}}$ | 1 k | $2-8$ | 14.7 MHz | 200 ns |
| 10 | $222 \Omega$ | $2-8$ | 4.5 MHz | 370 dB |  |
| 100 | $20 \Omega$ | $2-8$ | 960 kHz | $2.5 \mu \mathrm{~s}$ | 81 dB |

Figure 41. High Speed 3 Op Amp In Amp

## FEATURES

TRUE SINGLE SUPPLY OPERATION
Output Swings Rail to Rail
Input Voltage Range Extends Below Ground
Single Supply Capability from +3 V to +36 V
Dual Supply Capability from $\pm 1.5 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$
HIGH LOAD DRIVE
Capacitive Load Drive of 350 pF, G = 1
Minimum Output Current of 15 mA
EXCELLENT AC PERFORMANCE FOR LOW POWER
$800 \mu \mathrm{~A}$ Max Quiescent Current per Amplifier Unity Gain Bandwidth: 1.8 MHz
Slew Rate of $3.0 \mathrm{~V} / \mu \mathrm{s}$
GOOD DC PERFORMANCE
$800 \mu \mathrm{~V}$ Max Input Offset Voltage
$2 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ Typ Offset Voltage Drift
25 pA Max Input Bias Current
LOW NOISE
$13 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ @ 10 kHz
NO PHASE INVERSION

## APPLICATIONS

Battery Powered Precision Instrumentation
Photodiode Preamps
Active Filters
12- to 14-Bit Data Acquisition Systems
Medical Instrumentation
Low Power References and Regulators

## PRODUCT DESCRIPTION

The AD820/AD822 are precision, low power FET input op amps that can operate from a single supply of +3.0 V to +36 V , or dual supplies of $\pm 1.5 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$. They have true single supply capability with an input voltage range extending below the negative rail, allowing them to accommodate input signals below ground in the single supply mode. Output voltage swing


Input Voltage Noise vs. Frequency

## CONNECTION DIAGRAMS



8-Pin
SOIC
8-Pin Plastic DIP, Cerdip and SOIC
extends to within 10 mV of each rail providing the maximum output dynamic range.
Offset voltage of $800 \mu \mathrm{~V}$ max, offset voltage drift of $2 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$, input bias currents below 25 pA and low input voltage noise provide dc precision with source impedances up to a Gigaohm. 1.8 MHz unity gain bandwidth, -93 dB THD at 10 kHz and $3 \mathrm{~V} / \mu \mathrm{s}$ slew rate are provided with a low supply current of $800 \mu \mathrm{~A}$ per amplifier. The AD820 and AD822 drive up to 350 pF of direct capacitive load as a follower, and provides a minimum output current of 15 mA . This allows the amplifier to handle a wide range of load conditions. This combination of ac and dc performance, plus the outstanding load drive capability, results in an exceptionally versatile amplifier for the single supply user.

The AD820 and AD822 are available in four performance grades. The A and B grades are rated over the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. There is a 3 volt grade-the AD820A-3V or AD822A-3V, rated over the industrial temperature range. The AD822 is also available in a mil grade, is rated over the military temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$, and is processed on a standard military drawing.

The AD820 is offered in 8-pin plastic DIP and SOIC packaging while the AD822 is offered in three varieties of 8 -pin package: plastic DIP, hermetic cerdip and surface mount (SOIC) as well as die form.


Gain of +2 Amplifier; $V_{S}=+5,0, V_{I N}=2.5 V$ Sine Centered at 1.25 Volts, $R_{L}=100 \mathrm{k} \Omega$



$\left(V_{S}= \pm 15 \mathrm{~V} @ \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=0 \mathrm{~V}\right.$ unless otherwise noted)




NOTES
${ }^{1}$ See standard military drawing for 883 B specifications.
${ }^{2}$ This is a functional specification. Amplifier bandwidth decreases when the input common-mode voltage is driven in the range ( $+\mathrm{V}_{\mathrm{S}}-1 \mathrm{~V}$ ) to $+\mathrm{V}_{\mathrm{S}}$. Commonmode error voltage is typically less than 5 mV with the common-mode voltage set at 1 volt below the positive supply.
${ }^{3} \mathrm{~V}_{\mathrm{OL}}-\mathrm{V}_{\mathrm{EE}}$ is defined as the difference between the lowest possible output voltage ( $\mathrm{V}_{\mathrm{OL}}$ ) and the minus voltage supply rail ( $\mathrm{V}_{\mathrm{EE}}$ ). $\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{OH}}$ is defined as the difference between the highest possible output voltage $\left(\mathrm{V}_{\mathrm{OH}}\right)$ and the positive supply voltage $\left(\mathrm{V}_{\mathrm{CC}}\right)$.
Specifications subject to change without notice.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD820 and AD822 feature proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$



## MAXIMUM POWER DISSIPATION

The maximum power that can be safely dissipated by the AD820 or AD822 is limited by the associated rise in junction temperature. For plastic packages, the maximum safe junction temperature is $145^{\circ} \mathrm{C}$. For the cerdip packages, the maximum junction temperature is $175^{\circ} \mathrm{C}$. If these maximums are exceeded momentarily, proper circuit operation will be restored as soon as the die temperature is reduced. Leaving the device in the "overheated" condition for an extended period can result in device burnout. To ensure proper operation, it is important to observe the derating curves shown in Figure 24.
While the AD820 and AD822 are internally short circuit protected, this may not be sufficient to guarantee that the maximum junction temperature is not exceeded under all conditions. With power supplies $\pm 12$ volts (or less) at an ambient temperature of $+25^{\circ} \mathrm{C}$ or less, if the output node is shorted to a supply rail, then the amplifier will not be destroyed, even if this condition persists for an extended period.

## ORDERING GUIDE

| Model ${ }^{1}$ | Temperature Range | Package <br> Description | Package Option ${ }^{2}$ |
| :---: | :---: | :---: | :---: |
| AD820AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic Mini-DIP | N-8 |
| AD820BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic Mini-DIP | N-8 |
| AD820AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin SOIC | R-8 |
| AD820BR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin SOIC | R-8 |
| AD820AR-3V | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin SOIC | R-8 |
| AD820AN-3V | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic Mini-DIP | N-8 |
| AD822AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic Mini-DIP | N-8 |
| AD822BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic Mini-DIP | N-8 |
| AD822AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin SOIC | R-8 |
| AD822BR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin SOIC | R-8 |
| AD822AR-3V | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin SOIC | R-8 |
| AD822AN-3V | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic Mini-DIP | N-8 |
| AD822A Chips | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Die |  |
| Standard Military Drawing ${ }^{3}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Cerdip | Q-8 |

## NOTES

${ }^{1}$ AD822 Spice model is available on ADI Model Disc.
${ }^{2}$ For outline information see Package Information section.
${ }^{3}$ Contact factory for availability.



Figure 1a. AD820 Typical Distribution of Offset Voltage (248 Units)


Figure 1b. AD822 Typical Distribution of Offset Voltage (390 Units)


Figure 2a. AD820 Typical Distribution of Offset Voltage Drift (120 Units)


Figure 2b. AD822 Typical Distribution of Offset Voltage Drift (100 Units)


Figure 3. Typical Distribution of Input Bias Current (213 Units)


Figure 4. Input Bias Current vs. Common-Mode Voltage; $V_{s}=+5 \mathrm{~V}, 0 \mathrm{~V}$ and $V_{s}= \pm 5 \mathrm{~V}$


Figure 5. Input Bias Current vs. Common-Mode Voltage; $V_{s}= \pm 15 \mathrm{~V}$


Figure 6. Input Bias Current vs. Temperature; $V_{S}=5 V, V_{C M}=0$


Figure 7a. AD820 Open-Loop Gain vs. Load Resistance


Figure 7b. AD822 Open-Loop Gain vs. Load Resistance


Figure 8. Open-Loop Gain vs. Temperature


Figure 9. Input Error Voltage vs. Output Voltage for Resistive Loads


Figure 10. Input Error Voltage with Output Voltage within 300 mV of Either Supply Rail for Various Resistive Loads; $V_{s}= \pm 5 \mathrm{~V}$


Figure 11. Input Voltage Noise vs. Frequency


Figure 12. Total Harmonic Distortion vs. Frequency


Figure 13. Open-Loop Gain and Phase Margin vs. Frequency


Figure 14. Output Impedance vs. Frequency


Figure 15. Output Swing and Error vs. Settling Time


Figure 16. Common-Mode Rejection vs. Frequency


Figure 17. Absolute Common-Mode Error vs. CommonMode Voltage from Supply Rails $\left(V_{S}-V_{C M}\right)$


Figure 18. Output Saturation Voltage vs. Load Current


Figure 19. Output Saturation Voltage vs. Temperature


Figure 20. Short Circuit Current Limit vs. Temperature


Figure 21. Quiescent Current vs. Supply Voltage vs. Temperature

## AD820/AD822-Typical Characteristics



Figure 22a. AD820 Power Supply Rejection vs. Frequency


Figure 22b. AD822 Power Supply Rejection vs. Frequency


Figure 23. Large Signal Frequency Response


Figure 24. Maximum Power Dissipation vs. Temperature for Plastic and Hermetic Packages


Figure 25. Crosstalk vs. Frequency (AD822)


Figure 26. Unity-Gain Follower


Figure 27. $20 \mathrm{~V} \mathrm{p-p}$,25 kHz Sine Wave Input; Unity Gain Follower; $R_{L}=600 \Omega, V_{S}= \pm 15 \mathrm{~V}$


Figure 28. Crosstalk Test Circuit


Figure 29. Large Signal Response Unity Gain Follower; $V_{S}= \pm 15 \mathrm{~V}, R_{L}=10 \mathrm{k} \Omega$


Figure 30. Small Signal Response Unity Gain Follower; $V_{S}= \pm 15 \mathrm{~V}, R_{L}=10 \mathrm{k} \Omega$


Figure 31. $V_{S}=+5 \mathrm{~V}, 0 \mathrm{~V}$; Unity Gain Follower Response to 0 V to 4 V Step


Figure 32. Unity-Gain Follower


Figure 33. Gain of Two Inverter


Figure 34. $V_{s}=+5 \mathrm{~V}, 0 \mathrm{~V}$; Unity Gain Follower Response to $0 V$ to $5 V$ Step

## AD820/AD822-Typical Characteristics



Figure 35. $V_{S}=+5 \mathrm{~V}, 0 \mathrm{~V}$; Unity Gain Follower Response, to 40 mV Step Centered 40 mV Above Ground, $R_{L}=10 \mathrm{k} \Omega$


Figure 36. $V_{S}=+5 \mathrm{~V}, 0 \mathrm{~V}$; Gain of Two Inverter Response to 20 mV Step, Centered 20 mV Below Ground, $R_{L}=10 \mathrm{k} \Omega$


Figure 37. $V_{S}=+5 V, 0 V$; Gain of Two Inverter Response to 2.5 V Step Centered -1.25 V Below Ground, $R_{L}=10 \mathrm{k} \Omega$


Figure 38. $V_{S}=3 \mathrm{~V}, 0 \mathrm{~V}$; Gain of Two Inverter, $V_{I N}=1.25 \mathrm{~V}$, 25 kHz , Sine Wave Centered at $-0.75 \mathrm{~V}, R_{L}=600 \Omega$


Figure 39. (a) Response with $R_{P}=0 ; V_{I N}$ from 0 to $+V_{S}$ (b) $V_{I N}=0$ to $+V_{S}+200 \mathrm{mV}, V_{\text {OUT }}=0$ to $+V_{S}$, $R_{P}=49.9 \mathrm{k} \Omega$

## APPLICATION NOTES <br> INPUT CHARACTERISTICS

In the AD820 and AD822, n-channel JFETs are used to provide a low offset, low noise, high impedance input stage. Minimum input common-mode voltage extends from 0.2 V below $-\mathrm{V}_{\mathrm{S}}$ to 1 V less than $+\mathrm{V}_{\mathrm{S}}$. Driving the input voltage closer to the positive rail will cause a loss of amplifier bandwidth (as can be seen by comparing the large signal responses shown in Figures 31 and 34) and increased common-mode voltage error as illustrated in Figure 17.

The AD820 and AD822 do not exhibit phase reversal for input voltages up to and including $+V_{\mathrm{S}}$. Figure 39 a shows the response of a voltage follower to a 0 V to $+5 \mathrm{~V}\left(+\mathrm{V}_{\mathrm{S}}\right)$ square wave input. The input and output are superimposed. The output tracks the input up to $+\mathrm{V}_{\mathrm{S}}$ without phase reversal. The reduced bandwidth above a 4 V input causes the rounding of the output wave form. For input voltages greater than $+V_{S}$, a resistor in series with the noninverting input will prevent phase reversal, at the expense of greater input voltage noise. This is illustrated in Figure 39b.
Since the input stage uses n-channel JFETs, input current during normal operation is negative; the current flows out from the input terminals. If the input voltage is driven more positive than $+\mathrm{V}_{\mathrm{S}}-0.4 \mathrm{~V}$, the input current will reverse direction as internal device junctions become forward biased. This is illustrated in Figure 4.
A current limiting resistor should be used in series with the input of the AD820 or AD822 if there is a possibility of the input voltage exceeding the positive supply by more than 300 mV , or if an input voltage will be applied to the AD820 or AD822 when $\pm \mathrm{V}_{\mathrm{S}}=0$. The amplifier will be damaged if left in that condition for more than 10 seconds. A $1 \mathrm{k} \Omega$ resistor allows the amplifier to withstand up to 10 volts of continuous overvoltage, and increases the input voltage noise by a negligible amount.
Input voltages less than $-V_{S}$ are a completely different story. The amplifier can safely withstand input voltages 20 volts below the minus supply voltage as long as the total voltage from the positive supply to the input terminal is less than 36 volts. In addition, the input stage typically maintains picoamp level input currents across that input voltage range.


Figure 40. Total Noise vs. Source Impedance

The AD820 and AD822 are designed for $13 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ wideband input voltage noise and maintain low noise performance to low frequencies (refer to Figure 11). This noise performance, along with the low input current and current noise means that the AD820 and AD822 contribute negligible noise for applications with source resistances greater than $10 \mathrm{k} \Omega$ and signal bandwidths greater than 1 kHz . This is illustrated in Figure 40.

## OUTPUT CHARACTERISTICS

The AD820/AD822's unique bipolar rail-to-rail output stage swings within 5 mV of the minus supply and 10 mV of the positive supply with no external resistive load. The approximate output saturation resistance is $40 \Omega$ sourcing and $20 \Omega$ sinking. This can be used to estimate output saturation voltage when driving heavier current loads. For instance, when sourcing 5 mA , the saturation voltage to the positive supply rail will be 200 mV , when sinking 5 mA , the saturation voltage to the minus rail will be 100 mV .
The amplifier's open-loop gain characteristic will change as a function of resistive load, as shown in Figures 7 through 10. For load resistances over $20 \mathrm{k} \Omega$, the AD820/AD822's input error voltage is virtually unchanged until the output voltage is driven to 180 mV of either supply.
If the AD820/AD822's output is overdriven so as to saturate either of the output devices, the amplifier will recover within 2 $\mu \mathrm{s}$ of its input returning to the amplifier's linear operating region.
Direct capacitive loads will interact with the amplifier's effective output impedance to form an additional pole in the amplifier's feedback loop, which can cause excessive peaking on the pulse response or loss of stability. Worst case is when the amplifier is used as a unity gain follower. Figure 41 shows the AD820/ AD822's pulse response as a unity gain follower driving 350 pF . This amount of overshoot indicates approximately 20 degrees of phase margin-the system is stable, but is nearing the edge. Configurations with less loop gain, and as a result less loop bandwidth, will be much less sensitive to capacitance load effects. Figure 42 is a plot of capacitive load that will result in a 20 degree phase margin versus noise gain for the AD820/ AD822. Noise gain is the inverse of the feedback attenuation factor provided by the feedback network in use.


Figure 41. Small Signal Response of AD820/AD822 as Unity Gain Follower Driving 350 pF Capacitive Load



Figure 42. Capacitive Load Tolerance vs. Noise Gain
Figure 43 shows a method for extending capacitance load drive capability for a unity gain follower. With these component values, the circuit will drive $5,000 \mathrm{pF}$ with a $10 \%$ overshoot.


Figure 43. Extending Unity Gain Follower Capacitive Load Capability Beyond 350 pF

## OFFSET VOLTAGE ADJUSTMENT

The AD820's offset voltage is low, so external offset voltage nulling is not usually required. Figure 44 shows the recommended technique for AD820's packaged in plastic DIPs.
Adjusting offset voltage in this manner will change the offset


Figure 44. AD820 Offset Null
voltage temperature drift by $4 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ for every millivolt of induced offset. The null pins are not functional for AD820s in the SO-8 " R " package.

## APPLICATIONS-AD820

## Single Supply Half-Wave and Full-Wave Rectifiers

An AD820 configured as a unity gain follower and operated with a single supply can be used as a simple half-wave rectifier. The AD820's inputs maintain picoamp level input currents even when driven well below the minus supply. The rectifier puts that behavior to good use, maintaining an input impedance of over $10^{11} \Omega$ for input voltages from 1 volt from the positive supply to 20 volts below the negative supply.
The full and half-wave rectifier shown in Figure 45 operates as follows: when $\mathrm{V}_{\text {IN }}$ is above ground, R1 is bootstrapped through the unity gain follower A1 and the loop of amplifier A2. This forces the inputs of A 2 to be equal, thus no current flows through R1 or R2, and the circuit output tracks the input. When $\mathrm{V}_{\mathrm{IN}}$ is below ground, the output of A 1 is forced to ground. The noninverting input of amplifier A2 sees the ground level output of A1, therefore A2 operates as a unity gain inverter. The output at node C is then a full-wave rectified version of the input. Node B is a buffered half-wave rectified version of the input. Input voltages up to $\pm 18$ volts can be rectified, depending on the voltage supply used.


Figure 45. AD820 Single Supply Half- and Full-Wave Rectifier

### 4.5 Volt Low Dropout, Low Power Reference

The rail-to-rail performance of the AD820 can be used to provide low dropout performance for low power reference circuits powered with a single low voltage supply. Figure 46 shows a 4.5 volt reference using the AD820 and the AD680, a low power 2.5 volt bandgap reference. R2 and R3 set up the required gain of 1.8 to develop the 4.5 volt output. R1 and C2 form a lowpass RC filter to reduce the noise contribution of the AD680.


Figure 46. AD820 Single Supply 4.5 Volt Low Dropout Reference
With a 1 mA load, this reference maintains the 4.5 volt output with a supply voltage down to 4.7 volts. The amplitude of the recovery transient for a 1 mA to 10 mA step change in load current is under 20 mV , and settles out in a few microseconds. Output voltage noise is less than $10 \mu \mathrm{~V}$ rms in a 25 kHz noise bandwidth.

## Low Power Three-Pole Sallen Key Low-Pass Filter

The AD820's high input impedance makes it a good selection for active filters. High value resistors can be used to construct low frequency filters with capacitors much less than $1 \mu \mathrm{~F}$. The AD820's picoamp level input currents contribute minimal dc errors.

Figure 47 shows an example, a 10 Hz three-pole Sallen Key Filter. The high value used for R1 minimizes interaction with signal source resistance. Pole placement in this version of the filter minimizes the Q associated with the two-pole section of the filter. This eliminates any peaking of the noise contribution of resistors R1, R2, and R3, thus minimizing the inherent output voltage noise of the filter.


Figure 47. AD820 10 Hz Sallen Key Low-Pass Filter

## APPLICATIONS-AD822

Single Supply Voltage-to-Frequency Converter
The circuit shown in Figure 48 uses the AD822 to drive a low power timer, which produces a stable pulse of width $t_{1}$. The positive going output pulse is integrated by $\mathrm{R} 1-\mathrm{Cl}$ and used as one input to the AD822, which is connected as a differential integrator. The other input (nonloading) is the unknown voltage, $\mathrm{V}_{\mathrm{IN}}$. The AD822 output drives the timer trigger input, closing the overall feedback loop.


Figure 48. Single Supply Voltage-to-Frequency Converter
Typical AD822 bias currents of 2 pA allow megaohm-range source impedances with negligible dc errors. Linearity errors on the order of $0.01 \%$ full scale can be achieved with this circuit. This performance is obtained with a 5 volt single supply which delivers less than 1 mA to the entire circuit.
Single Supply Programmable Gain Instrumentation Amplifier The AD822 can be configured as a single supply instrumentation amplifier that is able to operate from single supplies down to 3 V , or dual supplies up to $\pm 15 \mathrm{~V}$. Using only one AD822 rather than three separate op amps, this circuit is cost and power efficient. AD822 FET inputs' 2 pA bias currents minimize offset errors caused by high unbalanced source impedances.

Table I. AD822 In Amp Performance

| Parameters | $\mathrm{V}_{\mathrm{s}}=3 \mathrm{~V}, 0 \mathrm{~V}$ | $\mathrm{V}_{\mathrm{s}}= \pm 5 \mathrm{~V}$ |
| :---: | :---: | :---: |
| CMRR | 74 dB | 80 dB |
| Common-Mode |  |  |
| Voltage Range | -0.2 V to +2 V | -5.2 V to +4 V |
| $3 \mathrm{~dB} \mathrm{BW}, \mathrm{G}=10$ | 180 kHz | 180 kHz |
| $\mathrm{G}=100$ | 18 kHz | 18 kHz |
| $\mathrm{t}_{\text {SETTLING }}$ |  |  |
| $2 \mathrm{~V} \operatorname{Step}\left(\mathrm{~V}_{\mathrm{S}}=0 \mathrm{~V}, 3 \mathrm{~V}\right)$ | $2 \mu \mathrm{~s}$ |  |
| $5 \mathrm{~V}\left(\mathrm{~V}_{\mathrm{S}}= \pm 5 \mathrm{~V}\right)$ |  | $5 \mu \mathrm{~s}$ |
| Noise @ $\mathrm{f}=1 \mathrm{kHz}, \mathrm{G}=10$ | $270 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ | $270 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| $\mathrm{G}=100$ | $2.2 \mu \mathrm{~V} / \sqrt{\mathrm{Hz}}$ | $2.2 \mu \mathrm{~V} / \sqrt{\mathrm{Hz}}$ |
| $\mathrm{I}_{\text {SUPPLY }}$ (Total) | 1.10 mA | 1.15 mA |

An array of precision thin-film resistors sets the in amp gain to be either 10 or 100 . These resistors are laser-trimmed to ratio match to $0.01 \%$, and have a maximum differential TC of $5 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$.


Figure 49a. Pulse Response of In Amp to a 500 mV p-p Input Signal; $V_{S}=+5 \mathrm{~V}, 0 \mathrm{~V}$; Gain $=10$


Figure 49b. A Single Supply Programmable Instrumentation Amplifier

## 3 Volt, Single Supply Stereo Headphone Driver

The AD822 exhibits good current drive and THD + N performance, even at 3 V single supplies. At 1 kHz , total harmonic distortion plus noise (THD +N ) equals $-62 \mathrm{~dB}(0.079 \%)$ for a 300 mV p-p output signal. This is comparable to other single supply op amps which consume more power and cannot run on 3 V power supplies.
In Figure 50, each channel's input signal is coupled via a $1 \mu \mathrm{~F}$ Mylar capacitor. Resistor dividers set the dc voltage at the noninverting inputs so that the output voltage is midway between the power supplies $(+1.5 \mathrm{~V})$. The gain is 1.5 . Each half of the AD822 can then be used to drive a headphone channel. A 5 Hz high-pass filter is realized by the $500 \mu \mathrm{~F}$ capacitors and the headphones, which can be modeled as 32 ohm load resistors to ground. This ensures that all signals in the audio frequency range ( $20 \mathrm{~Hz}-20 \mathrm{kHz}$ ) are delivered to the headphones.


Figure 50. 3 Volt Single Supply Stereo Headphone Driver

## Low Dropout Bipolar Bridge Driver

The AD822 can be used for driving a 350 ohm Wheatstone bridge. Figure 51 shows one half of the AD822 being used to buffer the AD589-a 1.235 V low power reference. The output of +4.5 V can be used to drive an A/D converter front end. The other half of the AD822 is configured as a unity-gain inverter, and generates the other bridge input of -4.5 V . Resistors R1 and R2 provide a constant current for bridge excitation. The AD620 low power instrumentation amplifier is used to condition the differential output voltage of the bridge. The gain of the AD620 is programmed using an external resistor $R_{G}$, and determined by:

$$
G=\frac{49.4 k \Omega}{R_{G}}+1
$$



Figure 51. Low Dropout Bipolar Bridge Driver

FEATURES
High Speed:
50 MHz Unity Gain Bandwidth
350 V/ $\mu$ s Slew Rate
70 ns Settling Time to $\mathbf{0 . 0 1 \%}$
Low Power:
7.5 mA Max Power Supply Current Per Amp

Easy to Use:
Drives Unlimited Capacitive Loads
50 mA Min Output Current Per Amplifier
Specified for $+5 \mathrm{~V}, \pm 5 \mathrm{~V}$ and $\pm 15 \mathrm{~V}$ Operation
2.0 V p-p Output Swing into a $150 \Omega$ Load $\left(V_{s}=+5 \mathrm{~V}\right)$
Good Video Performance
Differential Gain \& Phase Error of $\mathbf{0 . 0 7 \%}$ \& $\mathbf{0 . 1 1 ^ { \circ }}$
Excellent DC Performance:
2.0 mV Max Input Offset Voltage

## APPLICATIONS

Unity Gain ADC/DAC Buffer

## Cable Drivers

8- and 10-Bit Data Acquisition Systems
Video Line Driver
Active Filters

## PRODUCT DESCRIPTION

The AD826 is a dual, high speed voltage feedback op amp. It is ideal for use in applications which require unity gain stability and high output drive capability, such as buffering and cable driving. The 50 MHz bandwidth and $350 \mathrm{~V} / \mu \mathrm{s}$ slew rate make the AD826 useful in many high speed applications including: video, CATV, copiers, LCDs, image scanners and fax machines.

CONNECTION DIAGRAM<br>8-Pin Plastic Mini-DIP and SO Package



The AD826 features high output current drive capability of $50 \mathrm{~mA} \min$ per amp, and is able to drive unlimited capacitive loads. With a low power supply current of 15 mA max for both amplifiers, the AD826 is a true general purpose operational amplifier.
The AD826 is ideal for power sensitive applications such as video cameras and portable instrumentation. The AD826 can operate from a single +5 V supply, while still achieving 25 MHz of bandwidth. Furthermore the AD826 is fully specified from a single +5 V to $\pm 15 \mathrm{~V}$ power supplies.
The AD826 excels as an ADC/DAC buffer or active filter in data acquisition systems and achieves a settling time of 70 ns to $0.01 \%$, with a low input offset voltage of 2 mV max. The AD826 is available in small 8-pin plastic mini-DIP and SO packages.


Driving a Large Capacitive Load


| Parameter | Conditions | $\mathbf{V}_{\mathbf{S}}$ | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DYNAMIC PERFORMANCE <br> Unity Gain Bandwidth | Gain $=+1$ |  |  |  |  |  |
|  |  | $\pm 5 \mathrm{~V}$ $\pm 15 \mathrm{~V}$ | 30 45 | $\begin{aligned} & 35 \\ & 50 \end{aligned}$ |  | $\begin{aligned} & \mathrm{MHz} \\ & \mathrm{MHz} \end{aligned}$ |
|  |  | $0,+5 \mathrm{~V}$ | 25 | 29 |  | MHz |
| Bandwidth for 0.1 dB Flatness |  | $\pm 5 \mathrm{~V}$ | 10 | 20 |  | MHz |
|  |  | $\pm 15 \mathrm{~V}$ | 25 | 55 |  | MHz |
|  |  | $0,+5 \mathrm{~V}$ |  | 20 |  | MHz |
| Full Power Bandwidth ${ }^{1}$ | $\begin{aligned} & \mathrm{V}_{\text {OUT }}=5 \mathrm{~V} \mathrm{p}-\mathrm{p} \\ & \mathrm{R}_{\text {LOAD }}=500 \Omega \\ & \mathrm{~V}_{\text {OUT }}=20 \mathrm{~V} \mathrm{p}-\mathrm{p} \end{aligned}$ |  |  |  |  |  |
|  |  | $\pm 5 \mathrm{~V}$ |  | 15.9 |  | MHz |
|  |  |  |  |  |  |  |
|  | $\mathrm{R}_{\text {LOAD }}=1 \mathrm{k} \Omega$ | $\pm 15 \mathrm{~V}$ |  | 5.6 |  | MHz |
| Slew Rate | $\mathrm{R}_{\text {LOAD }}=1 \mathrm{k} \Omega$ | $\pm 5 \mathrm{~V}$ | 200 | 250 |  | V/ $/ \mathrm{s}$ |
|  | Gain $=-1$ | $\pm 15 \mathrm{~V}$ | 300 | 350 |  | V/us |
|  |  | $0,+5 \mathrm{~V}$ | 150 | 200 |  | $\mathrm{V} / \mathrm{\mu s}$ |
| Settling Time to 0.1\% | -2.5V to +2.5 V | $\pm 5 \mathrm{~V}$ |  | 45 |  |  |
|  | $0 \mathrm{~V}-10 \mathrm{~V}$ Step, $\mathrm{A}_{\mathrm{V}}=-1$ | $\pm 15 \mathrm{~V}$ |  | 45 |  | ns |
| to 0.01\% | -2.5 V to +2.5 V | $\pm 5 \mathrm{~V}$ |  | 70 |  | ns |
|  | $0 \mathrm{~V}-10 \mathrm{~V}$ Step, $\mathrm{A}_{\mathrm{V}}=-1$ | $\pm 15 \mathrm{~V}$ |  | 70 |  | ns |
| NOISE/HARMONIC PERFORMANCE |  |  |  |  |  |  |
| Total Harmonic Distortion | $\mathrm{F}_{\mathrm{C}}=1 \mathrm{MHz}$ | $\pm 15 \mathrm{~V}$ |  | -78 |  |  |
| Input Voltage Noise | $\mathrm{f}=10 \mathrm{kHz}$ | $\pm 5 \mathrm{~V}, \pm 15 \mathrm{~V}$ |  | 15 |  | $\mathrm{nV} / \sqrt{\overline{\mathrm{Hz}}}$ |
| Input Current Noise | $\mathrm{f}=10 \mathrm{kHz}$ | $\pm 5 \mathrm{~V}, \pm 15 \mathrm{~V}$ |  | 1.5 |  | $\mathrm{pA} / \sqrt{\overline{\mathrm{Hz}}}$ |
| Differential Gain Error$(\mathrm{Rl}=150 \Omega)$ | NTSC | $\pm 15 \mathrm{~V}$ |  | 0.07 | 0.1 |  |
|  | Gain $=+2$ | $\pm 5 \mathrm{~V}$ |  | 0.12 | 0.15 |  |
|  |  | $0,+5 \mathrm{~V}$ |  | 0.15 |  |  |
| Differential Phase Error$(\mathrm{RI}=150 \Omega)$ | NTSC | $\pm 15 \mathrm{~V}$ |  | 0.11 | 0.15 | Degrees |
|  | Gain $=+2$ | $\pm 5 \mathrm{~V}$ |  | 0.12 | 0.15 | Degrees |
|  |  | $0,+5 \mathrm{~V}$ |  | 0.15 |  | Degrees |
| DC PERFORMANCE <br> Input Offset Voltage |  | $\pm 5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$ |  | 0.5 | 2 | mV |
|  | $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |  |  |  | 3 | mV |
| Offset Drift |  |  |  | 10 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Bias Current |  | $\pm 5 \mathrm{~V}, \pm 15 \mathrm{~V}$ |  | 3.3 | 6.6 |  |
|  | $\mathrm{T}_{\text {MIN }}$ |  |  |  | 10 | $\mu \mathrm{A}$ |
|  | $\mathrm{T}_{\text {MAX }}$ |  |  |  | 4.4 |  |
| Input Offset CurrentOffset Current Drift | $\mathrm{T}_{\text {MIN }} \text { to } \mathrm{T}_{\text {MAX }}$ | $\pm 5 \mathrm{~V}, \pm 15 \mathrm{~V}$ |  | 25 | 200 | nA |
|  |  |  |  |  | 500 |  |
|  |  |  |  | 0.3 |  | $n \mathrm{n} /{ }^{\circ} \mathrm{C}$ |
| Open-Loop Gain | $\mathrm{V}_{\text {OUT }}= \pm 2.5 \mathrm{~V}$ | $\pm 5 \mathrm{~V}$ |  |  |  |  |
|  | $\mathrm{R}_{\text {LOAD }}=500 \Omega$ |  |  | 4 |  | V/mV |
|  | $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |  | 1.5 |  |  | $\mathrm{V} / \mathrm{mV}$ |
|  | $\mathrm{R}_{\text {LOAD }}=150 \Omega$ |  |  | 3 |  | V/mV |
|  | $\mathrm{V}_{\text {OUt }}= \pm 10 \mathrm{~V}$ | $\pm 15 \mathrm{~V}$ |  |  |  |  |
|  | $\mathbf{R}_{\text {LOAD }}=1 \mathrm{k} \Omega$ |  |  |  |  |  |
|  | $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |  |  | $5$ |  | $\mathrm{V} / \mathrm{mV}$ |
|  | $\begin{aligned} & \mathrm{V}_{\text {OUT }}= \pm 7.5 \mathrm{~V} \\ & \mathrm{R}_{\text {LOAD }}=150 \Omega(50 \mathrm{~mA} \text { Output }) \end{aligned}$ | $\pm 15 \mathrm{~V}$ | 2 | 4 |  | $\mathrm{V} / \mathrm{mV}$ |
| INPUT CHARACTERISTICS <br> Input Resistance <br> Input Capacitance <br> Input Common-Mode Voltage Range |  |  |  |  |  |  |
|  |  |  |  | 300 |  | $\mathrm{k} \Omega$ |
|  |  |  |  | 1.5 |  | pF |
|  |  | $\pm 5 \mathrm{~V}$ |  | +4.3 |  | V |
|  |  |  | -2.7 | -3.4 |  | V |
|  |  | $\pm 15 \mathrm{~V}$ | +13 | +14.3 |  | V |
|  |  |  | -12 | -13.4 |  | V |
|  |  | $0,+5 \mathrm{~V}$ | +3.8 | +4.3 |  | V |
|  |  |  | +1.2 | +0.9 |  | V |
| Common-Mode Rejection Ratio | $\mathrm{V}_{\mathrm{CM}}= \pm 2.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{MIN}}-\mathrm{T}_{\mathrm{MAX}}$ | $\pm 5 \mathrm{~V}$ | 80 | 100 |  | dB |
|  | $\mathrm{V}_{\mathrm{CM}}= \pm 12 \mathrm{~V}$ | $\pm 15 \mathrm{~V}$ | 86 | 120 |  | dB |
|  | $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ | $\pm 15 \mathrm{~V}$ | 80 | 100 |  | dB |


| Parameter | Conditions | $\mathbf{V}_{\mathbf{s}}$ | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| OUTPUT CHARACTERISTICS <br> Output Voltage Swing <br> Output Current <br> Short-Circuit Current Output Resistance | $\begin{aligned} & \mathrm{R}_{\text {LOAD }}=500 \Omega \\ & \mathrm{R}_{\text {LOAD }}=150 \Omega \\ & \mathrm{R}_{\text {LOAD }}=1 \mathrm{k} \Omega \\ & \mathrm{R}_{\text {LOAD }}=500 \Omega \\ & \mathrm{R}_{\text {LOAD }}=500 \Omega \end{aligned}$ <br> Open Loop | $\begin{aligned} & \pm 5 \mathrm{~V} \\ & \pm 5 \mathrm{~V} \\ & \pm 15 \mathrm{~V} \\ & \pm 15 \mathrm{~V} \\ & 0,+5 \mathrm{~V} \\ & \\ & \pm 15 \mathrm{~V} \\ & \pm 5 \mathrm{~V} \\ & 0,+5 \mathrm{~V} \\ & \pm 15 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 3.3 \\ & 3.2 \\ & 13.3 \\ & 12.8 \\ & +1.5 \\ & +3.5 \\ & 50 \\ & 50 \\ & 30 \end{aligned}$ | 3.8 <br> 3.6 <br> 13.7 $13.4$ <br> 90 <br> 8 |  | $\begin{aligned} & \pm \mathrm{V} \\ & \pm \mathrm{V} \\ & \pm \mathrm{V} \\ & \pm \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~mA} \\ & \mathrm{~mA} \\ & \mathrm{~mA} \\ & \mathrm{~mA} \\ & \Omega \end{aligned}$ |
| MATCHING CHARACTERISTICS <br> Dynamic <br> Crosstalk <br> Gain Flatness Match <br> Slew Rate Match <br> DC <br> Input Offset Voltage Match <br> Input Bias Current Match <br> Open-Loop Gain Match <br> Common-Mode Rejection Ratio Match <br> Power Supply Rejection Ratio Match | $\begin{aligned} & \mathrm{f}=5 \mathrm{MHz} \\ & \mathrm{G}=+1, \mathrm{f}=40 \mathrm{MHz} \\ & \mathrm{G}=-1 \\ & \\ & \mathrm{~T}_{\mathrm{MIN}}-\mathrm{T}_{\mathrm{MAX}} \\ & \mathrm{~T}_{\mathrm{MIN}}-\mathrm{T}_{\mathrm{MAX}} \\ & \mathrm{~V}_{\mathrm{O}}= \pm 10 \mathrm{~V}, \mathrm{R}_{\mathrm{LOAD}}=1 \mathrm{k} \Omega, \\ & \mathrm{~T}_{\mathrm{MIN}}-\mathrm{T}_{\mathrm{MAX}} \\ & \mathrm{~V}_{\mathrm{CM}}= \pm 12 \mathrm{~V}, \mathrm{~T}_{\mathrm{MIN}}-\mathrm{T}_{\mathrm{MAX}} \\ & \pm 5 \mathrm{~V} \text { to } \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{MIN}}-\mathrm{T}_{\mathrm{MAX}} \end{aligned}$ | $\begin{aligned} & \pm 15 \mathrm{~V} \\ & \pm 15 \mathrm{~V} \\ & \pm 15 \mathrm{~V} \\ & \pm 5 \mathrm{~V} \text { to } \pm 15 \mathrm{~V} \\ & \pm 5 \mathrm{~V} \text { to } \pm 15 \mathrm{~V} \\ & \\ & \pm 15 \mathrm{~V} \\ & \pm 15 \mathrm{~V} \end{aligned}$ | $0.15$ $80$ $80$ | $\begin{aligned} & -80 \\ & 0.2 \\ & 10 \\ & \\ & 0.5 \\ & 0.06 \\ & \\ & 0.01 \\ & 100 \\ & 100 \end{aligned}$ | 2 0.8 | dB <br> dB <br> $\mathrm{V} / \mu \mathrm{s}$ <br> mV <br> $\mu \mathrm{A}$ <br> $\mathrm{mV} / \mathrm{V}$ <br> dB <br> dB |
| POWER SUPPLY <br> Operating Range <br> Quiescent Current/Amplifier <br> Power Supply Rejection Ratio | Dual Supply <br> Single Supply <br> $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ <br> $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ <br> $\mathrm{V}_{\mathrm{S}}= \pm 5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}, \mathrm{~T}_{\text {MIN }}$ to $\mathrm{T}_{\mathrm{MAX}}$ | $\begin{aligned} & \pm 5 \mathrm{~V} \\ & \pm 5 \mathrm{~V} \\ & \pm 15 \mathrm{~V} \\ & \pm 15 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & \pm 2.5 \\ & +5 \end{aligned}$ <br> 75 | $\begin{aligned} & 6.6 \\ & \\ & 6.8 \\ & 86 \end{aligned}$ | $\begin{aligned} & \pm 18 \\ & +36 \\ & 7.5 \\ & 7.5 \\ & 7.5 \\ & 7.5 \end{aligned}$ | V mA mA mA mA dB |

## NOTE

${ }^{1}$ Full power bandwidth $=$ slew rate $/ 2 \pi \mathrm{~V}_{\text {PEAK }}$.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 18$ V
Internal Power Dissipation ${ }^{2}$
Plastic (N) . . . . . . . . . . . . . . . . . . See Derating Curves
Small Outline (R) . . . . . . . . . . . . . . See Derating Curves
Input Voltage (Common Mode) . . . . . . . . . . . . . . . . . $\pm \mathrm{V}_{\mathrm{S}}$
Differential Input Voltage . . . . . . . . . . . . . . . . . . . . $\pm 6$ V
Output Short Circuit Duration . . . . . . . . See Derating Curves
Storage Temperature Range (N, R) . . . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Operating Temperature Range . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Lead Temperature Range (Soldering 10 seconds) . . . . $+300^{\circ} \mathrm{C}$
NOTES
${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ Specification is for device in free air: 8 -pin plastic package, $\theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} /$ watt; 8 -pin SOIC package, $\theta_{\mathrm{JA}}=155^{\circ} \mathrm{C} /$ watt.

## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD826AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | N-8 |
| AD826AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | R-8 |
| AD826AR-REEL | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8 -Pin Plastic SOIC | R-8 |

$\star$ For outline information see Package Information section.

## ESD SUSCEPTIBILITY

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 volts, which readily accumulate on the human body and on test equipment, can discharge without detection. Although the AD826 features proprietary ESD protection circuitry, permanent damage may still occur on these devices if they are subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid any performance degradation or loss of functionality.


[^143]
## AD826 - Typical Characteristics



Figure 1. Common-Mode Voltage Range vs. Supply


Figure 2. Output Voltage Swing vs. Supply


Figure 3. Output Voltage Swing vs. Load Resistance


Figure 4. Quiescent Supply Current per Amp vs. Supply Voltage for Various Temperatures


Figure 5. Slew Rate vs. Supply Voltage


Figure 6. Closed-Loop Output Impedance vs. Frequency


Figure 7. Input Bias Current vs. Temperature


Figure 8. Short Circuit Current vs. Temperature


Figure 9. Unity Gain Bandwidth and Phase Margin vs. Temperature


Figure 10. Open-Loop Gain and Phase Margin vs. Frequency


Figure 11. Open-Loop Gain vs. Load Resistance


Figure 12. Power Supply Rejection vs. Frequency

## AD826-Typical Characteristics



Figure 13. Common-Mode Rejection vs. Frequency


Figure 14. Large Signal Frequency Response


Figure 15. Output Swing and Error vs. Settling Time


Figure 16. Harmonic Distortion vs. Frequency


Figure 17. Input Voltage Noise Spectral Density


Figure 18. Slew Rate vs. Temperature


Figure 19. Closed-Loop Gain vs. Frequency


Figure 20. Differential Gain and Phase vs. Supply Voltage


Figure 21. Crosstalk vs. Frequency


Figure 22. Closed-Loop Gain vs. Frequency, Gain $=-1$


Figure 23. Gain Flatness Matching vs. Supply, $G=+1$

$R_{L}=150 \Omega F O R \pm V_{S}=5 \mathrm{~V}, 1 \mathrm{k} \Omega F O R \pm V_{S}=15 \mathrm{~V}$
USE GROUND PLANE
PINOUT SHOWN IS FOR MINIDIP PACKAGE
Figure 24. Crosstalk Test Circuit

## AD826-Typical Characteristics



Figure 25. Noninverting Amplifier Configuration


Figure 26. Noninverting Large Signal Pulse Response, $R_{L}=1 \mathrm{k} \Omega$


Figure 27. Noninverting Large Signal Pulse Response, $R_{L}=150 \Omega$


Figure 28. Noninverting Small Signal Pulse Response, $R_{L}=1 \mathrm{k} \Omega$


Figure 29. Noninverting Small Signal Pulse Response, $R_{L}=150 \Omega$


Figure 30. Inverting Amplifier Configuration


Figure 31. Inverting Large Signal Pulse Response, $R_{L}=1 \mathrm{k} \Omega$


Figure 32. Inverting Large Signal Pulse Response, $R_{L}=150 \Omega$


Figure 33. Inverting Small Signal Pulse Response, $R_{L}=1 \mathrm{k} \Omega$


Figure 34. Inverting Small Signal Pulse Response, $R_{L}=150 \Omega$

## THEORY OF OPERATION

The AD826 is a low cost, wide band, high performance dual operational amplifier which can drive heavy capacitive and resistive loads. It also achieves a constant slew rate, bandwidth and settling time over its entire specified temperature range.
The AD826 (Figure 35) consists of a degenerated NPN differential pair driving matched PNPs in a folded-cascode gain stage. The output buffer stage employs emitter followers in a class AB amplifier which delivers the necessary current to the load while maintaining low levels of distortion.


Figure 35. Simplified Schematic
The capacitor, $\mathrm{C}_{\mathrm{F}}$, in the output stage mitigates the effect of capacitive loads. With low capacitive loads, the gain from the compensation node to the output is very close to unity. In this case, $\mathrm{C}_{\mathrm{F}}$ is bootstrapped and does not contribute to the overall compensation capacitance of the device. As the capacitive load is increased, a pole is formed with the output impedance of the output stage. This reduces the gain, and therefore, $\mathrm{C}_{\mathrm{F}}$ is incompletely bootstrapped. Effectively, some fraction of $C_{F}$ contributes to the overall compensation capacitance, reducing the unity gain bandwidth. As the load capacitance is further increased, the bandwidth continues to fall, maintaining the stability of the amplifier.

## INPUT CONSIDERATIONS

An input protection resistor ( $\mathrm{R}_{\mathrm{IN}}$ in Figure 25) is required in circuits where the input to the AD826 will be subjected to transient or continuous overload voltages exceeding the $\pm 6 \mathrm{~V}$ maximum differential limit. This resistor provides protection for the input transistors by limiting their maximum base current.
For high performance circuits, it is recommended that a "balancing" resistor be used to reduce the offset errors caused by bias current flowing through the input and feedback resistors. The balancing resistor equals the parallel combination of $\mathrm{R}_{\mathrm{IN}}$ and $\mathrm{R}_{\mathrm{F}}$ and thus provides a matched impedance at each input terminal. The offset voltage error will then be reduced by more than an order of magnitude.

## APPLYING THE AD826

The AD826 is a breakthrough dual amp that delivers precision and speed at low cost with low power consumption. The AD826 offers excellent static and dynamic matching characteristics, combined with the ability to drive heavy resistive and capacitive loads.
As with all high frequency circuits, care should be taken to maintain overall device performance as well as their matching. The following items are presented as general design considerations.

## Circuit Board Layout

Input and output runs should be laid out so as to physically isolate them from remaining runs. In addition, the feedback resistor of each amplifier should be placed away from the feedback resistor of the other amplifier, since this greatly reduces inter-amp coupling.

## Choosing Feedback and Gain Resistors

In order to prevent the stray capacitance present at each amplifier's summing junction from limiting its performance, the feedback resistors should be $\leq 1 \mathrm{k} \Omega$. Since the summing junction capacitance may cause peaking, a small capacitor ( $1-5 \mathrm{pF}$ ) may be paralleled with Rf to neutralize this effect. Finally, sockets should be avoided, because of their tendency to increase interlead capacitance.

## Power Supply Bypassing

Proper power supply decoupling is critical to preserve the integrity of high frequency signals. In carefully laid out designs, decoupling capacitors should be placed in close proximity to the supply pins, while their lead lengths should be kept to a minimum. These measures greatly reduce undesired inductive effects on the amplifier's response.
Though two $0.1 \mu \mathrm{~F}$ capacitors will typically be effective in decoupling the supplies, several capacitors of different values can be paralleled to cover a wider frequency range.

## $\pm$ SINGLE SUPPLY OPERATION

An exciting feature of the AD826 is its ability to perform well in a single supply configuration (see Figure 37). The AD826 is ideally suited for applications that require low power dissipation and high output current and those which need to drive large capacitive loads, such as high speed buffering and instrumentation.
Referring to Figure 36, careful consideration should be given to the proper selection of component values. The choices for this particular circuit are: $(\mathrm{R} 1+\mathrm{R} 3) \| \mathrm{R} 2$ combine with C 1 to form a low frequency corner of approximately 30 Hz .


Figure 36. Single Supply Amplifier Configuration

R3 and C2 reduce the effect of the power supply changes on the output by low pass filtering with a corner at $\frac{1}{2 \pi R_{3} C_{2}}$.
The values for $R_{L}$ and $C_{L}$ were chosen to demonstrate the AD826's exceptional output drive capability. In this configuration, the output is centered around 2.5 V . In order to eliminate the static dc current associated with this level, C3 was inserted in series with $\mathbf{R}_{\mathbf{L}}$.


Figure 37. Single Supply Pulse Response, $G=+1$, $R_{L}=150 \Omega, C_{L}=200 \mathrm{pF}$

## PARALLEL AMPS PROVIDE 100 mA TO LOAD

By taking advantage of the superior matching characteristics of the AD826, enhanced performance can easily be achieved by employing the circuit in Figure 38. Here, two identical cells are paralleled to obtain even higher load driving capability than that of a single amplifier ( $100 \mathrm{~mA} \min$ guaranteed). R1 and R2 are included to limit current flow between amplifier outputs that would arise in the presence of any residual mismatch.


Figure 38. Parallel Amp Configuration

## SINGLE-ENDED TO DIFFERENTIAL LINE DRIVER

Outstanding CMRR ( $>80 \mathrm{~dB} @ 5 \mathrm{MHz}$ ), high bandwidth, wide supply voltage range, and the ability to drive heavy loads, make the AD826 an ideal choice for many line driving applications. In this application, the AD830 high speed video difference amp serves as the differential line receiver on the end of a back terminated, 50 ft ., twisted-pair transmission line (see Figure 40 ). The overall system is configured in a gain of +1 and has a -3 dB bandwidth of 14 MHz . Figure 39 is the pulse response with a 2 V p-p, 1 MHz signal input.


Figure 39. Pulse Response


Figure 40. Differential Line Driver

## LOW DISTORTION LINE DRIVER

The AD826 can quickly be turned into a powerful, low distortion line driver (see Figure 41). In this arrangement the AD826 can comfortably drive a $75 \Omega$ back-terminated cable, with a $5 \mathrm{MHz}, 2 \mathrm{~V}$ p-p input; all of this while achieving the harmonic distortion performance outlined in the following table.

| Configuration | 2nd Harmonic |
| :--- | :---: |
| 1. No Load | -78.5 dBm |
| 2. $150 \Omega \mathrm{R}_{\mathrm{L}}$ Only | -63.8 dBm |
| 3. $150 \Omega \mathrm{R}_{\mathrm{L}} 7.5 \Omega \mathrm{R}_{\mathrm{C}}$ | -70.4 dBm |

In this application one half of the AD826 operates at a gain of 2.1 and supplies the current to the load, while the other provides the overall system gain of 2 . This is important for two reasons: the first is to keep the bandwidth of both amplifiers the same, and the second is to preserve the AD826's ability to operate from low supply voltages. $\mathrm{R}_{\mathrm{C}}$ varies with the load and must be chosen to satisfy the following equation:

$$
R_{C}=M R_{L},
$$

where $M$ is defined by $\left[(M+1) G_{S}=G_{D}\right]$ and $G_{D}=$ Driver's Gain, $\mathrm{G}_{\mathrm{S}}=$ System Gain.


Figure 41. Low Distortion Amplifier

## HIGH PERFORMANCE ADC BUFFER

Figure 42 is a schematic of a 12-bit high speed analog-to-digital converter. The AD826 dual op amp takes a single ended input and drives the AD872 A/D converter differentially, thus reducing 2nd harmonic distortion. Figure 43 is a FFT of a 1 MHz input, sampled at 10 MHz with a THD of -78 dB . The AD826 can be used to amplify low level signals so that the entire range of the converter is used. The ability of the AD826 to perform on a $\pm 5$ volt supply or even with a single 5 volts combined with its rapid settling time and ability to deliver high current to complicated loads make it a very good flash $\mathrm{A} / \mathrm{D}$ converter buffer as well as a very useful general purpose building block.


Figure 42. A Differential Input Buffer for High Bandwidth ADCs


Figure 43. FFT, Buffered A/D Converter

## FEATURES

HIGH SPEED
50 MHz Unity Gain Stable Operation
300 V/us Slew Rate
120 ns Settling Time
Drives Unlimited Capacitive Loads
EXCELLENT VIDEO PERFORMANCE
0.04\% Differential Gain @ 4.4 MHz
$0.19^{\circ}$ Differential Phase @ 4.4 MHz
GOOD DC PERFORMANCE
$2 \mathbf{m V}$ max Input Offset Voltage $15 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ Input Offset Voltage Drift
Available in Tape and Reel in Accordance with EIA-481A Standard

## LOW POWER

Only 10 mA Total Supply Current for Both Amplifiers $\pm 5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$ Supplies

## PRODUCT DESCRIPTION

The AD827 is a dual version of Analog Devices' industrystandard AD847 op amp. Like the AD847, it provides high speed, low power performance at low cost. The AD827 achieves a $300 \mathrm{~V} / \mu \mathrm{s}$ slew rate and 50 MHz unity-gain bandwidth while consuming only 100 mW when operating from $\pm 5$ volt power supplies. Performance is specified for operation using $\pm 5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$ power supplies.
The AD827 offers an open-loop gain of 3,500 V/V into $500 \Omega$ loads. It also features a low input voltage noise of $15 \mathrm{nV} / \sqrt{\mathrm{Hz}}$, and a low input offset voltage of 2 mV maximum. Commonmode rejection ratio is a minimum of 80 dB . Power supply rejection ratio is maintained at better than 20 dB with input frequencies as high as 1 MHz , thus minimizing noise feedthrough from switching power supplies.
The AD827 is also ideal for use in demanding video applications, driving coaxial cables with less than $0.04 \%$ differential gain and $0.19^{\circ}$ differential phase errors for 643 mV p-p into a $75 \Omega$ reverse terminated cable.
The AD827 is also useful in multichannel, high speed data conversion systems where its fast ( 120 ns to $0.1 \%$ ) settling time is of importance. In such applications, the AD827 serves as an input buffer for 8 -bit to 10 -bit A/D converters and as an output amplifier for high speed D/A converters.

## CONNECTION DIAGRAMS



## APPLICATION HIGHLIGHTS

1. Performance is fully specified for operation using $\pm 5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$ supplies.
2. A $0.04 \%$ differential gain and $0.19^{\circ}$ differential phase error at the 4.4 MHz color subcarrier frequency, together with its low cost, make it ideal for many video applications.
3. The AD827 can drive unlimited capacitive loads, while its 30 mA output current allows $50 \Omega$ and $75 \Omega$ reverseterminated loads to be driven.
4. The AD827's 50 MHz unity-gain bandwidth makes it an ideal candidate for multistage active filters.
5. The AD827 is available in 8-pin plastic mini-DIP and cerdip, 20-pin LCC, and 16 -pin SOIC packages. Chips and MIL-STD-883B processing are also available. complete data sheet, call our fax retrieval system at 1-800-446-6212.


| Model | Conditions | $\mathbf{V}_{\text {s }}$ | AD827J |  |  | AD827A/S |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max | Min | Typ | Max |  |
| POWER SUPPLY |  |  |  |  |  |  |  |  |  |
| Operating Range | $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ | $\pm 5 \mathrm{~V}$ | $\pm 4.5$ | 10 | $\pm 18$ | $\pm 4.5$ | 10 | $\pm 18$ | VmA |
| Quiescent Current |  |  |  |  | 13 |  |  | 13 |  |
|  |  |  |  |  | 16 |  |  | 16.5/17.5 | mA |
| - |  | $\pm 15 \mathrm{~V}$ |  | 10.5 | 13.5 |  | 10.5 | 13.5 | mA |
|  | $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ |  |  |  | 16.5 |  |  | 17/18 | mA |
| TRANSISTOR COUNT |  |  |  | 92 |  |  | 92 |  |  |

## NOTES

${ }^{1}$ Offset voltage for the AD827 is guaranteed after power is applied and the device is fully warmed up. All other specifications are measured using high speed test equipment, approximately 1 second after power is applied.
${ }^{2}$ Full Power Bandwidth $=$ Slew Rate $/ 2 \pi \mathrm{~V}_{\text {PEAK }}$.
${ }^{3}$ Gain $=+1$, rising edge.
All min and max specifications are guaranteed.
Specifications subject to change without notice.


NOTES
${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum ratings for extended periods may affect device reliability.
${ }^{2}$ Maximum internal power dissipation is specified so that $T_{J}$ does not exceed
$+175^{\circ} \mathrm{C}$ at an ambient temperature of $+25^{\circ} \mathrm{C}$.
Thermal Characteristics:
Mini-DIP: $\theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} /$ Watt; $\theta_{\mathrm{JC}}=33^{\circ} \mathrm{C} /$ Watt
Cerdip: $\theta_{\mathrm{JA}}=110^{\circ} \mathrm{C} / \mathrm{W}$ att; $\theta_{\mathrm{JC}}=30^{\circ} \mathrm{C} / \mathrm{Watt}$
$16-$ Pin Small Outline Package: $\theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} / \mathrm{Watt}$
20-Pin LCC: $\theta_{\mathrm{JA}}=150^{\circ} \mathrm{C} /$ Watt; $\theta_{\mathrm{JC}}=35^{\circ} \mathrm{C} /$ Watt
${ }^{3}$ Indefinite short circuit duration is only permissible as long as the absolute maximum power rating is not exceeded.

## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD827JN | 0 to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | N-8 |
| AD827JR | 0 to $+70^{\circ} \mathrm{C}$ | 16-Pin Plastic SO | R-16 |
| AD827AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Cerdip | Q-8 |
| AD827SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Cerdip | Q-8 |
| AD827SQ/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Cerdip | Q-8 |
| 5962-9211701MPA | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Cerdip | Q-8 |
| AD827SE/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 20-Pin LCC | E-20A |
| 5962-9211701M2A | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 20-Pin LCC | E-20A |
| AD827JR-REEL | 0 to $+70^{\circ} \mathrm{C}$ | Tape \& Reel |  |
| AD827JChips | 0 to $+70^{\circ} \mathrm{C}$ | Die |  |
| AD827SChips | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Die |  |

[^144]
## METALIZATION PHOTOGRAPH

Contact factory for latest dimensions. Dimensions shown in inches and (mm). Substrate is connected to $\mathrm{V}+$.


## FEATURES

## Excellent Video Performance

Differential Gain \& Phase Error of 0.01\% \& 0.05 ${ }^{\circ}$
High Speed
130 MHz 3 dB Bandwidth ( $\mathrm{G}=+2$ )
450 V/ $\mu \mathrm{s}$ Slew Rate
80 ns Settling Time to $\mathbf{0 . 0 1 \%}$
Low Power
15 mA Max Power Supply Current
High Output Drive Capability: 50 mA Minimum Output Current per Amplifier Ideal for Driving Back Terminated Cables
Flexible Power Supply Specified for $+5 \mathrm{~V}, \pm 5 \mathrm{~V}$ and $\pm 15 \mathrm{~V}$ Operation $\pm 3.2 \mathrm{~V}$ min Output Swing into a $150 \Omega$ Load $\left(\mathrm{V}_{\mathrm{s}}= \pm 5 \mathrm{~V}\right)$
Excellent DC Performance 2.0 mV Input Offset Voltage

Available in 8-Pin SOIC and 8-Pin Plastic Mini-DIP

## FUNCTIONAL BLOCK DIAGRAM



## PRODUCT DESCRIPTION

The AD828 is a low cost, dual video op amp optimized for use in video applications which require gains of +2 or greater and high output drive capability, such as cable driving. Due to its low power and single supply functionality, along with excellent differential gain and phase errors, the AD828 is ideal for power sensitive applications such as video cameras and professional video equipment.
With video specs like 0.1 dB flatness to 40 MHz and low differential gain and phase errors of $0.01 \%$ and $0.05^{\circ}$, along with 50 mA of output current per amplifier, the AD828 is an excellent choice for any video application. The 130 MHz gain bandwidth and $450 \mathrm{~V} / \mu \mathrm{s}$ slew rate make the AD828 useful in many high speed applications including: video monitors, CATV, color copiers, image scanners and fax machines.


AD828 Video Line Driver

The AD828 is fully specified for operation with a single +5 V power supply and with dual supplies from $\pm 5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$. This power supply flexibility, coupled with a very low supply current of 15 mA and excellent ac characteristics under all power supply conditions, make the AD828 the ideal choice for many demanding yet power sensitive applications.

The AD828 is a voltage feedback op amp which excels as a gain stage (gains $>+2$ ) or active filter in high speed and video systems and achieves a settling time of 45 ns to $0.1 \%$, with a low input offset voltage of 2 mV max.
The AD828 is available in low cost, small 8-pin plastic miniDIP and SOIC packages.


## AD828-SPECIFICATIONS

(@ $T_{A}=+25^{\circ} \mathrm{C}$, unless otherwise noted)

| Parameter | Conditions | $\mathbf{V}_{\mathbf{s}}$ | Min | $\begin{aligned} & \text { AD828 } \\ & \text { Typ } \end{aligned}$ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DYNAMIC PERFORMANCE - 3 dB Bandwidth | Gain $=+2$ |  |  |  |  |  |
|  |  | $\pm 5 \mathrm{~V}$ $\pm 15 \mathrm{~V}$ | 60 100 | 85 130 |  | $\begin{aligned} & \mathrm{MHz} \\ & \mathrm{MHz} \end{aligned}$ |
|  |  | $0,+5 \mathrm{~V}$ | 30 | 45 |  | MHz |
|  | Gain $=-1$ | $\pm 5 \mathrm{~V}$ | 35 | 55 |  | MHz |
|  |  | $\pm 15 \mathrm{~V}$ | 60 | 90 |  | MHz |
|  |  | $0,+5 \mathrm{~V}$ | 20 | 35 |  | MHz |
| Bandwidth for 0.1 dB Flatness | $\begin{aligned} & \text { Gain }=+2 \\ & \mathrm{C}_{\mathrm{C}}=1 \mathrm{pF} \end{aligned}$ | $\pm 5 \mathrm{~V}$ | 30 | 43 |  | MHz |
|  |  | $\pm 15 \mathrm{~V}$ | 30 | 40 |  | MHz |
|  |  | $0,+5 \mathrm{~V}$ | 10 | 18 |  | MHz |
|  | $\begin{aligned} & \text { Gain }=-1 \\ & \mathrm{C}_{\mathrm{C}}=1 \mathrm{pF} \end{aligned}$ | $\pm 5 \mathrm{~V}$ | 15 | 25 |  | MHz |
|  |  | $\pm 15 \mathrm{~V}$ | 30 | 50 |  | MHz |
|  |  | $0,+5 \mathrm{~V}$ | 10 | 19 |  | MHz |
| Full Power Bandwidth ${ }^{1}$ | $\begin{gathered} \mathrm{V}_{\text {OUT }}=5 \mathrm{Vp} \mathrm{p} \mathrm{p} \\ \mathrm{R}_{\text {LOAD }}=500 \Omega \\ \mathrm{~V}_{\text {OUT }}=20 \mathrm{~V} \mathrm{p}-\mathrm{p} \\ \mathrm{R}_{\text {LOAD }}=1 \mathrm{k} \Omega \end{gathered}$ | $\pm 5 \mathrm{~V}$ |  | 22.3 |  | MHz |
|  |  | $\pm 15 \mathrm{~V}$ |  | 7.2 |  | MHz |
| Slew Rate |  | $\pm 5 \mathrm{~V}$ | 300 | 350 |  | V/us |
|  | Gain $=-1$ | $\pm 15 \mathrm{~V}$ | 400 | 450 |  | V/us |
|  |  | $0,+5 \mathrm{~V}$ | 200 | 250 |  | V/us |
| Settling Time to $0.1 \%$ | -2.5 V to +2.5 V$0-10 \mathrm{~V}$ Step, $\mathrm{A}_{\mathrm{V}}=-1$ | $\pm 5 \mathrm{~V}$ |  | 45 |  | ns |
|  |  | $\pm 15 \mathrm{~V}$ |  | 45 |  | ns |
| to $0.01 \%$ | $\begin{aligned} & -2.5 \mathrm{~V} \text { to }+2.5 \mathrm{~V} \\ & 0-10 \mathrm{~V} \text { Step, } \mathrm{A}_{\mathrm{V}}=-1 \end{aligned}$ | $\pm 5 \mathrm{~V}$ |  | 80 |  | ns |
|  |  | $\pm 15 \mathrm{~V}$ |  | 80 |  | ns |
| NOISE/HARMONIC PERFORMANCE |  |  |  |  |  |  |
| Total Harmonic Distortion | $\mathrm{F}_{\mathrm{C}}=1 \mathrm{MHz}$ | $\pm 15 \mathrm{~V}$ |  | -78 |  |  |
| Input Voltage Noise | $\mathrm{f}=10 \mathrm{kHz}$ | $\pm 5 \mathrm{~V}, \pm 15 \mathrm{~V}$ |  | 10 |  | $\mathrm{nV} / \sqrt{\overline{\mathrm{Hz}}}$ |
| Input Current Noise | $\mathrm{f}=10 \mathrm{kHz}$ | $\pm 5 \mathrm{~V}, \pm 15 \mathrm{~V}$ |  | 1.5 |  | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
| Differential Gain Error$\left(\mathrm{R}_{\mathrm{L}}=150 \Omega\right)$ | NTSC | $\pm 15 \mathrm{~V}$ |  | 0.01 | 0.02 | \% |
|  | Gain $=+2$ | $\pm 5 \mathrm{~V}$ |  | 0.02 | 0.03 |  |
|  |  | 0, +5 V |  | 0.08 |  |  |
| Differential Phase Error$\left(\mathrm{R}_{\mathrm{L}}=150 \Omega\right)$ | NTSCGain $=+2$ | $\pm 15 \mathrm{~V}$ |  | 0.05 | 0.09 | Degrees |
|  |  | $\pm 5 \mathrm{~V}$ |  | 0.07 | 0.1 | Degrees |
|  |  | $0,+5 \mathrm{~V}$ |  | 0.1 |  | Degrees |
| DC PERFORMANCE Input Offset Voltage |  |  |  |  |  |  |
|  | $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ | $\pm 5 \mathrm{~V}, \pm 15 \mathrm{~V}$ |  | 0.5 | 2 | mV |
|  |  |  |  |  | 3 | mV |
| Offset Drift |  |  |  | 10 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Bias Current |  | $\pm 5 \mathrm{~V}, \pm 15 \mathrm{~V}$ |  | 3.3 | 6.6 |  |
|  | $\mathrm{T}_{\text {MIN }}$ |  |  |  | 10 |  |
|  |  |  |  |  | 4.4 | $\mu \mathrm{A}$ |
| Input Offset Current |  | $\pm 5 \mathrm{~V}, \pm 15 \mathrm{~V}$ |  | 25 | 200 | nA |
|  | $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |  |  |  | 500 |  |
| Offset Current Drift |  |  |  | 0.3 |  | $n \mathrm{~A} /{ }^{\circ} \mathrm{C}$ |
| Open Loop Gain | $\begin{aligned} & \mathrm{V}_{\text {OUT }}= \pm 2.5 \mathrm{~V} \\ & \mathrm{R}_{\text {LOAD }}=500 \Omega \\ & \mathrm{~T}_{\text {MIN }} \text { to } \mathrm{T}_{\text {MAX }} \\ & \mathrm{R}_{\text {LOAD }}=150 \Omega \\ & \mathrm{~V}_{\text {OUT }}= \pm 10 \mathrm{~V} \\ & \mathrm{R}_{\text {LOAD }}=1 \mathrm{k} \Omega \\ & \mathrm{~T}_{\text {MIN }} \text { to } \mathrm{T}_{\text {MAX }} \\ & \mathrm{V}_{\text {OUT }}= \pm 7.5 \mathrm{~V} \\ & \mathrm{R}_{\text {LOAD }}=150 \Omega(50 \mathrm{~mA} \text { Output }) \end{aligned}$ | $\pm 5 \mathrm{~V}$ |  |  |  |  |
|  |  |  | 3 | 5 |  | $\mathrm{V} / \mathrm{mV}$ |
|  |  |  | 2 |  |  | $\mathrm{V} / \mathrm{mV}$ |
|  |  |  | 2 | 4 |  | $\mathrm{V} / \mathrm{mV}$ |
|  |  | $\pm 15 \mathrm{~V}$ |  |  |  |  |
|  |  |  | 5.5 | 9 |  | $\mathrm{V} / \mathrm{mV}$ |
|  |  |  | 2.5 |  |  | V/mV |
|  |  | $\pm 15 \mathrm{~V}$ | 3 | 5 |  | V/mV |
| INPUT CHARACTERISTICS |  |  |  |  |  |  |
|  |  |  |  |  |  |  |  |  |
| Input Resistance | , |  |  | 300 |  | k $\Omega$ |
| Input Common-Mode Voltage Range |  |  |  | 1.5 +4.3 |  | $\mathrm{V}_{\mathrm{V}}$ |
|  |  |  | +3.8 -2.7 | +3.4 |  | V |
|  |  | $\pm 15 \mathrm{~V}$ | +13 | +14.3 |  | V |
|  |  |  | $\bigcirc 12$ | -13.4 |  | V |
|  |  | $0,+5 \mathrm{~V}$ | +3.8 | +4.3 |  | V |
|  |  |  | ${ }_{+1.2}$ | +0.9 |  | V |
| Common-Mode Rejection Ratio |  | $\pm 5 \mathrm{~V}$ | 82 | 100 |  | dB |
|  | $\mathrm{V}_{\mathrm{CM}}= \pm 12 \mathrm{~V}$. | $\pm 15 \mathrm{~V}$ | 86 | 120 |  | ${ }_{\text {dB }}$ |
|  | $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ | $\pm 15 \mathrm{~V}$ | 84 | 100 |  | dB |



## NOTES

${ }^{1}$ Full power bandwidth $=$ slew rate $/ 2 \pi \mathrm{~V}_{\text {PEAK }}$.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 18$ V
Internal Power Dissipation ${ }^{2}$
Plastic DIP (N)
See Derating Curves
Small Outline (R) . . . . . . . . . . . . . . . See Derating Curves
Input Voltage (Common Mode) . . . . . . . . . . . . . . . . . . $\pm \mathrm{V}_{\mathrm{S}}$
Differential Input Voltage . . . . . . . . . . . . . . . . . . . . . $\pm 6$ V
Output Short Circuit Duration . . . . . . . . See Derating Curves
Storage Temperature Range (N, R) . . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Operating Temperature Range . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Lead Temperature Range (Soldering 10 seconds) . . . $+300^{\circ} \mathrm{C}$
NOTES
${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ Specification is for device in free air:
8-Pin Plastic DIP Package: $\theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} /$ Watt
8 -Pin SOIC Package: $\theta_{\mathrm{JA}}=155^{\circ} \mathrm{C} / \mathrm{W}$ att

## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD828AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | N-8 |
| AD828AR | $-40^{\circ}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | R-8 |
| AD828AR-REEL | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | R-8 |

$\star$ For outline information see Package Information section.


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## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD828 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

## AD828 - Typical Characteristics



Figure 1. Common-Mode Voltage Range vs. Supply Voltage


Figure 2. Output Voltage Swing vs. Supply Voltage


Figure 3. Output Voltage Swing vs. Load Resistance


Figure 4. Quiescent Supply Current per Amp vs. Supply Voltage for Various Temperatures


Figure 5. Slew Rate vs. Supply Voltage


Figure 6. Closed-Loop Output Impedance vs. Frequency


Figure 7. Input Bias Current vs. Temperature


Figure 8. Short Circuit Current vs. Temperature


Figure 9. $-3 d B$ Bandwidth and Phase Margin vs. Temperature. Gain $=+2$


Figure 10. Open-Loop Gain and Phase Margin vs. Frequency


Figure 11. Open-Loop Gain vs. Load Resistance


Figure 12. Power Supply Rejection vs. Frequency

## AD828 - Typical Characteristics



Figure 13. Common-Mode Rejection vs. Frequency


Figure 14. Large Signal Frequency Response


Figure 15. Output Swing and Error vs. Settling Time


Figure 16. Harmonic Distortion vs. Frequency


Figure 17. Input Voltage Noise Spectral Density vs. Frequency


Figure 18. Slew Rate vs. Temperature


Figure 19. Closed-Loop Gain vs. Frequency


Figure 20. Differential Gain and Phase vs. Supply Voltage


Figure 21. Crosstalk vs. Frequency


Figure 22. Closed-Loop Gain vs. Frequency, $G=-1$



USE GROUND PLANE
PINOUT SHOWN IS FOR MINIDIP PACKAGE
Figure 24. Crosstalk Test Circuit

## AD828 - Typical Characteristics



Figure 25. Inverting Amplifier Connection


Figure 26. Inverter Large Signal Pulse Response $\pm 5 V_{s}$, $C_{F}=1 \mathrm{pF}, R_{L}=1 \mathrm{k} \Omega$


Figure 27. Inverter Small Signal Pulse Response $\pm 5 V_{S}$, $C_{F}=1 \mathrm{pF}, R_{L}=150 \Omega$


Figure 28. Inverter Large Signal Pulse Response $\pm 15 V_{S}$, $C_{F}=1 \mathrm{pF}, R_{\mathrm{L}}=1 \mathrm{k} \Omega$


Figure 29. Inverter Small Signal Pulse Response $\pm 15 \mathrm{~V}_{\mathrm{S}}$, $C_{F}=1 \mathrm{pF}, R_{L}=150 \Omega$


Figure 30. Inverter Small Signal Pulse Response $\pm 5 V_{S}$ $C_{F}=0 p F, R_{L}=150 \Omega$


Figure 31. Noninverting Amplifier Connection


Figure 32. Noninverting Large Signal Pulse Response $\pm 5 V_{S}, C_{F}=1 p F, R_{L}=1 \mathrm{k} \Omega$


Figure 33. Noninverting Small Signal Pulse Response $\pm 5 V_{S^{\prime}} C_{F}=1 p F, R_{L}=150 \Omega$


Figure 34. Noninverting Large Signal Pulse Response $\pm 15 V_{S}, C_{F}=1 \mathrm{pF}, R_{L}=1 \mathrm{k} \Omega$


Figure 35. Noninverting Small Signal Pulse Response $\pm 15 V_{S}, C_{F}=1 p F, R_{L}=150 \Omega$


Figure 36. Noninverting Small Signal Pulse Response $\pm 5 V_{S}, C_{F}=0 p F, R_{L}=150 \Omega$

## AD828

## THEORY OF OPERATION

The AD828 is a low cost, dual video operational amplifier designed to excel in high performance, high output current video applications.
The AD828 (Figure 37) consists of a degenerated NPN differential pair driving matched PNPs in a folded-cascode gain stage. The output buffer stage employs emitter followers in a class AB amplifier that delivers the necessary current to the load while maintaining low levels of distortion.
The AD828 will drive terminated cables and capacitive loads of 10 pF or less. As the closed-loop gain is increased, the AD828 will drive heavier cap loads without oscillating.


Figure 37. AD828 Simplified Schematic

## INPUT CONSIDERATIONS

An input protection resistor ( $\mathrm{R}_{\mathrm{IN}}$ in Figure 31) is required in circuits where the input to the AD828 will be subjected to transient or continuous overload voltages exceeding the $\pm 6 \mathrm{~V}$ maximum differential limit. This resistor provides protection for the input transistors by limiting their maximum base current.
For high performance circuits, it is recommended that a "balancing" resistor be used to reduce the offset errors caused by bias current flowing through the input and feedback resistors. The balancing resistor equals the parallel combination of $R_{\text {IN }}$ and $\mathbf{R}_{\mathbf{F}}$ and thus provides a matched impedance at each input terminal. The offset voltage error will then be reduced by more than an order of magnitude.

## APPLYING THE AD828

The AD828 is a breakthrough dual amp that delivers precision and speed at low cost with low power consumption. The AD828 offers excellent static and dynamic matching characteristics, combined with the ability to drive heavy resistive loads.
As with all high frequency circuits, care should be taken to maintain overall device performance as well as their matching. The following items are presented as general design considerations.

## Circuit Board Layout

Input and output runs should be laid out so as to physically isolate them from remaining runs. In addition, the feedback resistor of each amplifier should be placed away from the feedback resistor of the other amplifier, since this greatly reduces interamp coupling.

## Choosing Feedback and Gain Resistors

In order to prevent the stray capacitance present at each amplifier's summing junction from limiting its performance, the feedback resistors should be $\leq 1 \mathrm{k} \Omega$. Since the summing junction capacitance may cause peaking, a small capacitor ( $1-5 \mathrm{pF}$ ) may be paralleled with Rf to neutralize this effect. Finally, sockets should be avoided, because of their tendency to increase interlead capacitance.

## Power Supply Bypassing

Proper power supply decoupling is critical to preserve the integrity of high frequency signals. In carefully laid out designs, decoupling capacitors should be placed in close proximity to the supply pins, while their lead lengths should be kept to a minimum. These measures greatly reduce undesired inductive effects on the amplifier's response.

Though two $0.1 \mu \mathrm{~F}$ capacitors will typically be effective in decoupling the supplies, several capacitors of different values can be paralleled to cover a wider frequency range.

## PARALLEL AMPS PROVIDE 100 mA TO LOAD

By taking advantage of the superior matching characteristics of the AD828, enhanced performance can easily be achieved by employing the circuit in Figure 38. Here, two identical cells are paralleled to obtain even higher load driving capability than that of a single amplifier ( 100 mA min guaranteed). R1 and R2 are included to limit current flow between amplifier outputs that would arise in the presence of any residual mismatch.


Figure 38. Parallel Amp Configuration


Figure 39. Bidirectional Transmission CKT

## Full-Duplex Transmission

Superior load handling capability ( $50 \mathrm{~mA} \mathrm{~min} / \mathrm{mm}$ ), high bandwidth, wide supply voltage range and excellent crosstalk rejection makes the AD828 an ideal choice even for the most demanding high speed transmission applications.
The schematic below shows a pair of AD828s configured to drive 100 feet of coaxial cable in a full-duplex fashion.
Two different NTSC video signals are simultaneously applied at $\mathrm{A}_{\mathrm{IN}}$ and $\mathrm{B}_{\mathrm{IN}}$ and are recovered at $\mathrm{A}_{\mathrm{OUT}}$ and $\mathrm{B}_{\mathrm{OUT}}$, respectively. This situation is illustrated in Figures 40 and 41 . These pictures


Figure 40. A Transmission/B Reception
clearly show that each input signal appears undisturbed at its output, while the unwanted signal is eliminated at either receiver.
The transmitters operate as followers, while the receivers' gain is chosen to take full advantage of the AD828's unparalled CMRR. (In practice this gain is adjusted slightly from its theoretical value to compensate for cable nonidealities and losses.) $\mathbf{R}_{\mathbf{Z}}$ is chosen to match the characteristic impedance of the cable employed.
Finally, although a coaxial cable was used, the same topology applies unmodified to a variety of cables (such, as twisted pairs often used in telephony).


Figure 41. B Transmission/A Reception

## A High Performance Video Line Driver

The buffer circuit shown in Figure 42 will drive a backterminated $75 \Omega$ video line to standard video levels ( 1 V p-p) with 0.1 dB gain flatness to 40 MHz with only $0.05^{\circ}$ and $0.01 \%$ differential phase and gain at the 3.58 MHz NTSC subcarrier frequency. This level of performance, which meets the requirements for high-definition video displays and test equipment, is achieved using only 7 mA quiescent current/amplifier.


Figure 42. Video Line Driver

## LOW DISTORTION LINE DRIVER

The AD828 can quickly be turned into a powerful, low distortion line driver (see Figure 43). In this arrangement the AD828 can comfortably drive a $75 \Omega$ back-terminated cable, with a $5 \mathrm{MHz}, 2 \mathrm{~V}$ p-p input; all of this while achieving the harmonic distortion performance outlined in the following table.

| Configuration | 2nd Harmonic |
| :--- | :---: |
| 1. No Load | -78.5 dBm |
| 2. $150 \Omega \mathrm{R}_{\mathrm{L}}$ Only | -63.8 dBm |
| 3. $150 \Omega \mathrm{R}_{\mathrm{L}} 7.5 \Omega \mathrm{R}_{\mathrm{C}}$ | -70.4 dBm |

In this application one half of the AD828 operates at a gain of 2.1 and supplies the current to the load, while the other provides the overall system gain of 2 . This is important for two reasons: the first is to keep the bandwidth of both amplifiers the same, and the second is to preserve the AD828's ability to operate from low supply voltage. $\mathbf{R}_{\mathrm{C}}$ varies with the load and must be chosen to satisfy the following equation:

$$
R_{C}=M R_{L},
$$

where $M$ is defined by $\left[(M+1) G_{S}=G_{D}\right]$ and $G_{D}=$ Driver's Gain, $\mathrm{G}_{\mathrm{s}}=$ System Gain.


Figure 43. Low Distortion Amplifier

## FEATURES

High Speed
120 MHz Bandwidth, Gain = -1
230 V/ $\mu$ s Slew Rate
90 ns Settling Time to 0.1\%
Ideal for Video Applications 0.02\% Differential Gain $0.04^{\circ}$ Differential Phase

## Low Noise

$1.7 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ Input Voltage Noise
$1.5 \mathrm{pA} / \sqrt{\mathrm{Hz}}$ Input Current Noise
Excellent DC Precision
1 mV max Input Offset Voltage (Over Temp)
$0.3 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ Input Offset Drift
Flexible Operation Specified for $\pm 5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$ Operation $\pm 3$ V Output Swing into a $150 \Omega$ Load External Compensation for Gains 1 to 20 5 mA Supply Current
Available in Tape and Reel in Accordance with EIA-481A Standard

## PRODUCT DESCRIPTION

The AD829 is a low noise ( $1.7 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ ), high speed op amp with custom compensation that provides the user with gains from $\pm 1$ to $\pm 20$ while maintaining a bandwidth greater than 50 MHz . The AD829's $0.04^{\circ}$ differential phase and $0.02 \%$ differential gain performance at 3.58 MHz and 4.43 MHz , driving reverse-terminated $50 \Omega$ or $75 \Omega$ cables, makes it ideally suited for professional video applications. The AD829 achieves its $230 \mathrm{~V} / \mu \mathrm{s}$ uncompensated slew rate and 750 MHz gain bandwidth product while requiring only 5 mA of current from the power supplies.
The AD829's external compensation pin gives it exceptional versatility. For example, compensation can be selected to optimize the bandwidth for a given load and power supply voltage. As a gain-of-two line driver, the -3 dB bandwidth can be increased to 95 MHz at the expense of 1 dB of peaking. In addition, the AD829's output can also be clamped at its external compensation pin.
The AD829 has excellent dc performance. It offers a minimum open-loop gain of $30 \mathrm{~V} / \mathrm{mV}$ into loads as low as $500 \Omega$, low input voltage noise of $1.7 \mathrm{nV} / \sqrt{\mathrm{Hz}}$, and a low input offset voltage of 1 mV maximum. Common-mode rejection and power supply rejection ratios are both 120 dB .
The AD829 is also useful in multichannel, high speed data conversion where its fast ( 90 ns to $0.1 \%$ ) settling time is of importance. In such applications, the AD829 serves as an input buffer for 8 -to-10-bit A/D converters and as an output I/V converter for high speed D/A converters.

## CONNECTION DIAGRAM

8-Pin Plastic Mini-DIP (N), Cerdip (Q) and SOIC (R) Packages


20-Pin LCC Pinout


NC = NO CONNECT
The AD829 provides many of the same advantages that a transimpedance amplifier offers, while operating as a traditional voltage feedback amplifier. A bandwidth greater than 50 MHz can be maintained for a range of gains by changing the external compensation capacitor. The AD829 and the transimpedance amplifier are both unity gain stable and provide similar voltage noise performance $(1.7 \mathrm{nV} / \sqrt{\mathrm{Hz}})$. However, the current noise of the AD829 ( $1.5 \mathrm{pA} / \sqrt{\mathrm{Hz}}$ ) is less than $10 \%$ of the noise of transimpedance amps. Furthermore, the inputs of the AD829 are symmetrical.

## PRODUCT HIGHLIGHTS

1. Input voltage noise of $2 \mathrm{nV} / \sqrt{\mathrm{Hz}}$, current noise of $1.5 \mathrm{pA} /$ $\sqrt{\mathrm{Hz}}$ and 50 MHz bandwidth, for gains of 1 to 20, make the AD829 an ideal preamp.
2. Differential phase error of $0.04^{\circ}$ and a $0.02 \%$ differential gain error, at the 3.58 MHz NTSC and 4.43 MHz PAL and SECAM color subcarrier frequencies, make it an outstanding video performer for driving reverse-terminated $50 \Omega$ and $75 \Omega$ cables to $\pm 1 \mathrm{~V}$ (at their terminated end).
3. The AD829 can drive heavy capacitive loads.
4. Performance is fully specified for operation from $\pm 5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$ supplies.
5. Available in plastic, cerdip, and small outline packages. Chips and MIL-STD-883B parts are also available.

AD829 - SDEGEAMATMN (@ $T_{A}=+25^{\circ} \mathrm{C}$ and $V_{S}= \pm 15 \mathrm{~V} d \mathrm{dc}$, unless otherwise noted)


| Model | Conditions | $\mathbf{V}_{\text {s }}$ | AD829J |  |  | AD829 A/S |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max | Min | Typ | Max |  |
| POWER SUPPLY |  |  |  |  |  |  |  |  |  |
| Operating Range |  |  | $\pm 4.5$ |  | $\pm 18$ | $\pm 4.5$ |  | $\pm 18$ | V |
| Quiescent Current |  | $\pm 5 \mathrm{~V}$ |  | 5 | 6.5 |  | 5 | 6.5 | mA |
|  | $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ |  |  |  | 8.0 |  |  | 8.2/8.7 | mA |
|  |  | $\pm 15 \mathrm{~V}$ |  | 5.3 | 6.8 |  | 5.3 |  | mA |
|  | $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ |  |  |  | 8.3 |  |  | 8.5/9.0 | mA |
| TRANSISTOR COUNT | Number of Transistors |  |  | 46 |  |  | 46 |  |  |

## NOTES

${ }^{1}$ Full Power Bandwidth $=$ Slew Rate $/ 2 \pi \mathrm{~V}_{\text {Peak }}$.
${ }^{2}$ Tested at Gain $=+20, \mathrm{C}_{\text {COMP }}=0 \mathrm{pF}$.
${ }^{3} 3.58 \mathrm{MHz}$ (NTSC) and 4.43 MHz (PAL \& SECAM).
${ }^{4}$ Differential input capacitance consists of 1.5 pF package capacitance plus 3.5 pF from the input differential pair.
Specifications subject to change without notice.

ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

| Supply Voltage |  |
| :---: | :---: |
| Internal Power Dissipation ${ }^{2}$ |  |
| Plastic (N) | . 3 Watts |
| Small Outline (R) | 0.9 Watts |
| Cerdip (Q) | 1.3 Watts |
| LCC (E) | 0.8 Watts |
| Input Voltage | $\pm \mathrm{V}_{\text {s }}$ |
| Differential Input Voltage ${ }^{3}$ | $\pm 6$ Volts |
| Output Short Circuit Duration | Indefinite |
| Storage Temperature Range (Q, E) | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Storage Temperature Range ( $\mathrm{N}, \mathrm{R}$ ) | $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Operating Temperature Range |  |
| AD829J | 0 to $+70^{\circ} \mathrm{C}$ |
| AD829A | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| AD829S | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Lead Temperaure Range (Sold | +300 |

## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ Maximum internal power dissipation is specified so that $\mathrm{T}_{\mathrm{J}}$ does not exceed $+175^{\circ} \mathrm{C}$ at an ambient temperature of $+25^{\circ} \mathrm{C}$.
Thermal characteristics:
8-pin plastic package: $\theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} /$ watt (derate at $8.7 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ )
8-pin cerdip package: $\theta_{\mathrm{JA}}=110^{\circ} \mathrm{C} /$ watt (derate at $8.7 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ )
20-pin LCC package: $\theta_{\mathrm{JA}}=150^{\circ} \mathrm{C} /$ watt
8 -pin small outline package: $\theta_{\mathrm{JA}}=155^{\circ} \mathrm{C} /$ watt (derate at $6 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ ).
${ }^{3}$ If the differential voltage exceeds 6 volts, external series protection resistors should be added to limit the input current.

## METALIZATION PHOTO

Contact factory for latest dimensions. Dimensions shown in inches and (mm).


## ESD SUSCEPTIBILITY

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 volts, which readily accumulate on the human body and on test equipment, can discharge without detection. Although the AD829 features proprietary ESD protection circuitry, permanent damage may still occur on these devices if they are subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid any performance degradation or loss of functionality.

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD829JN | 0 to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic Mini-DIP | N-8 |
| AD829JR | 0 to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | R-8 |
| AD829JR-REEL | 0 to $+70^{\circ} \mathrm{C}$ | Tape \& Reel | Q-8 |
| AD829AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Cerdip | Q-8 |
| AD829SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Cerdip | Q-8 |
| AD829SQ/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Cerdip | Q-8 |
| 5962-9312901MPA | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Cerdip | Q-8 |
| AD829SE/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 20-Pin LCC | E-20A |
| 5962-9312901M2A | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 20-Pin LCC | E-20A |
| AD829JChips | 0 to $+70^{\circ} \mathrm{C}$ | Die |  |
| AD829SChips | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Die |  |

[^146] High Speed, Video Difference Amplifier AD830

## FEATURES

Differential Amplification
Wide Common-Mode Voltage Range: +12.8 V, -12 V
Differential Voltage Range: $\pm 2 \mathrm{~V}$
High CMRR: 60 dB @ 4 MHz
Built-in Differential Clipping Level: $\pm 2.3 \mathrm{~V}$
Fast Dynamic Performance
85 MHz Unity Gain Bandwidth
35 ns Settling Time to 0.1\%
360 V/ $\mu \mathrm{s}$ Slew Rate
Symmetrical Dynamic Response
Excellent Video Specifications
Differential Gain Error: 0.06\%
Differential Phase Error: 0.08 ${ }^{\circ}$
$15 \mathrm{MHz}(0.1 \mathrm{~dB}$ ) Bandwidth
Flexible Operation
High Output Drive of $\pm \mathbf{5 0} \mathrm{mA}$ min Specified with Both $\pm 5 \mathrm{~V}$ and $\pm 15 \mathrm{~V}$ Supplies
Low Distortion: THD = -72 dB @ 4 MHz
Excellent DC Performance: $\mathbf{3} \mathbf{~ m V}$ max Input Offset Voltage

## APPLICATIONS

Differential Line Receiver
High Speed Level Shifter
High Speed In-Amp
Differential to Single Ended Conversion
Resistorless Summation and Subtraction
High Speed A/D Driver

## PRODUCT DESCRIPTION

The AD830 is a wideband, differencing amplifier designed for use at video frequencies but also useful in many other applications. It accurately amplifies a fully differential signal at the


Common-Mode Rejection Ratio vs. Frequency

CONNECTION DIAGRAM
8-Pin Plastic Mini-DIP (N), Cerdip (Q) and SOIC (R) Packages

input and produces an output voltage referred to a user-chosen level. The undesired common-mode signal is rejected, even at high frequencies. High impedance inputs ease interfacing to finite source impedances and thus preserve the excellent common-mode rejection. In many respects, it offers significant improvements over discrete difference amplifier approaches, in particular in high frequency common-mode rejection.
The wide common-mode and differential-voltage range of the AD830 make it particularly useful and flexible in level shifting applications, but at lower power dissipation than discrete solutions. Low distortion is preserved over the many possible differential and common-mode voltages at the input and output.
Good gain flatness and excellent differential gain of $0.06 \%$ and phase of $0.08^{\circ}$ make the AD830 suitable for many video system applications. Furthermore, the AD830 is suited for general purpose signal processing from dc to 10 MHz .


Closed-Loop Gain vs. Frequency, Gain $=+1$

SPECIF|CATIONS $\left(v_{S}= \pm 15 v, R_{\text {LOAD }}=150 \Omega, \mathrm{c}_{\text {LOAD }}=5 \mathrm{pF}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right.$ unless otherwise noted $)$
AD830


## NOTES

${ }^{1}$ See Standard Military Drawing 5962-9313001MPA for specifications.
${ }^{2}$ Clipping level function on X channel only.
Specifications subject to change without notice.

AD830-SPECIFICATIONS $\left(V_{S}= \pm 5 \mathrm{~V}, \mathrm{R}_{\mathrm{LOAD}}=150 \Omega, \mathrm{C}_{\mathrm{LOAD}}=5 \mathrm{pF}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right.$ unless otherwise noted $)$

| Parameter | Conditions | AD830J/A |  |  | AD830S ${ }^{1}$ |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max | Min | Typ | Max |  |
| DYNAMIC CHARACTERISTICS |  |  |  |  |  |  |  |  |
| 3 dB Small Signal Bandwidth | Gain $=1, \mathrm{~V}_{\text {OUt }}=100 \mathrm{mV}$ rms | 35 | 40 |  | 35 | 40 |  | MHz |
| 0.1 dB Gain Flatness Frequency | Gain $=1, \mathrm{~V}_{\text {OUt }}=100 \mathrm{mV} \mathrm{rms}$ | 5 | 6.5 |  | 5 | 6.5 |  | MHz |
| Differential Gain Error | 0 to +0.7 V , Frequency $=4.5 \mathrm{MHz}, \mathrm{G}=+2$ |  | 0.14 | 0.18 |  | 0.14 | 0.18 |  |
| Differential Phase Error | 0 to +0.7 V, Frequency $=4.5 \mathrm{MHz}, \mathrm{G}=+2$ |  | 0.32 | 0.4 |  | 0.32 | 0.4 | Degrees |
| Slew Rate, Gain = 1 | 2 V Step, $\mathrm{R}_{\mathrm{L}}=500 \Omega$ |  | 210 |  |  | 210 |  | V/us |
|  | 4 V Step, $\mathrm{R}_{\mathrm{L}}=500 \Omega$ |  | 240 |  |  | 240 |  | V/us |
| 3 dB Large Signal Bandwidth | Gain $=1, \mathrm{~V}_{\text {OUT }}=1 \mathrm{~V} \mathrm{rms}$ | 30 | 36 |  | 30 | 36 |  | MHz |
| Settling Time | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ Step, to $0.1 \%$ |  | 35 |  |  | 35 |  |  |
|  | $\mathrm{V}_{\text {OUT }}=4 \mathrm{~V}$ Step, to $0.1 \%$ |  | 48 |  |  | 48 |  |  |
| Harmonic Distortion | 2 V p-p, Frequency $=1 \mathrm{MHz}$ |  | -69 |  |  | -69 |  | dBc |
|  | 2 V p-p, Frequency $=4 \mathrm{MHz}$ |  | -56 |  |  | -56 |  | dBc |
| Input Voltage Noise | Frequency $=10 \mathrm{kHz}$ |  | 27 |  |  | 27 |  | $\mathrm{nV} / \sqrt{\underline{\mathrm{Hz}}}$ |
| Input Current Noise |  |  | 1.4 |  |  | 1.4 |  | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
| DC PERFORMANCE |  |  |  |  |  |  |  |  |
| Offset Voltage | Gain $=1$ |  | $\pm 1.5$ | $\pm 3$ |  | $\pm 1.5$ | $\pm 3$ | mV |
|  | Gain $=1, \mathrm{~T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ |  |  | $\pm 4$ |  |  | $\pm 5$ | mV |
| Open Loop Gain | DC | 60 | 65 |  | 60 | 65 |  | dB |
| Unity Gain Accuracy | $\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega$ |  | $\pm 0.1$ | $\pm 0.6$ |  | $\pm 0.1$ | $\pm 0.6$ |  |
| Peak Nonlinearity, $\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega$ | $-1 \mathrm{~V} \leq \mathrm{X} \leq+1 \mathrm{~V}$ |  | 0.01 | 0.03 |  | 0.01 | 0.03 | \% FS |
|  | $-1.5 \mathrm{~V} \leq \mathrm{X} \leq+1.5 \mathrm{~V}$ |  | 0.045 | 0.07 |  | 0.045 | 0.07 | \% FS |
|  | $-2 \mathrm{~V} \leq \mathrm{X} \leq+2 \mathrm{~V}$ |  | 0.23 | 0.4 |  | 0.23 | 0.4 | \% FS |
| Input Bias Current | $\mathrm{V}_{\text {IN }}=0 \mathrm{~V},+25^{\circ} \mathrm{C}$ to $\mathrm{T}_{\text {MAX }}$ |  | 5 | 10 |  | 5 | 10 | $\mu \mathrm{A}$ |
|  | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}, \mathrm{~T}_{\text {MIN }}$ |  | 7 | 13 |  | 8 | 17 | $\mu \mathrm{A}$ |
| Input Offset Current | $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}, \mathrm{~T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |  | 0.1 | 1 |  | 0.1 | 1 | $\mu \mathrm{A}$ |
| INPUT CHARACTERISTICS |  |  |  |  |  |  |  |  |
| Differential Voltage Range | $\mathrm{V}_{\mathrm{CM}}=0$ |  | $\pm 2.0$ |  |  | $\pm 2.0$ |  | V |
| Differential Clipping Level ${ }^{2}$ | Pins 1 and 2 Inputs Only | $\pm 2.0$ | $\pm 2.2$ |  | $\pm 2.0$ | $\pm 2.2$ |  | V |
| Common-Mode Voltage Range | $\mathrm{V}_{\mathrm{DM}}= \pm 1 \mathrm{~V}$ | -2.0 |  | +2.9 | -2.0 |  | +2.9 | V |
| CMRR | DC, Pins $1,2,+4 \mathrm{~V}$ to -2 V | 90 | 100 |  | 90 | 100 |  | dB |
|  | DC, Pins $1,2,+4 \mathrm{~V}$ to $-2 \mathrm{~V}, \mathrm{~T}_{\text {MIN }}-\mathrm{T}_{\mathrm{mAX}}$ | 88 |  |  | 86 |  |  | dB |
|  | Frequency $=4 \mathrm{MHz}$ | 55 | 60 |  |  | 60 |  | dB |
| Input Resistance |  |  | 370 |  |  | 370 |  | k $\Omega$ |
| Input Capacitance |  |  | 2 |  |  | 2 |  | pF |
| OUTPUT CHARACTERISTICS |  |  |  |  |  |  |  |  |
| Output Voltage Swing | $\mathrm{R}_{\mathrm{L}} \geq 150 \Omega$ | $\pm 3.2$ | $\pm 3.5$ |  | $\pm 3.2$ |  |  | V |
|  | $\mathrm{R}_{\mathrm{L}} \geq 150 \Omega, \pm 4 \mathrm{~V}_{\mathrm{s}}$ | $\pm 2.2$ | +2.7, -2.4 |  | $\pm 2.2$ | +2.7, -2.4 |  | V |
| Short Circuit Current | Short to Ground |  | -55, +70 |  |  | $-55,+70$ |  | mA |
| Output Current |  | $\pm 40$ |  |  | $\pm 40$ |  |  | mA |
| POWER SUPPLIES |  |  |  |  |  |  |  |  |
| Operating Range |  | $\pm 4$ |  | $\pm 16.5$ | $\pm 4$ |  | $\pm 16.5$ | V |
| Quiescent Current | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ |  | 13.5 | 16 |  | 13.5 |  | mA |
| + PSRR (to $\mathrm{V}_{\mathrm{P}}$ ) | DC, G = 1, Offset |  | 86 |  |  | 86 |  | dB |
| - PSRR (to $\mathrm{V}_{\mathrm{N}}$ ) | DC, G = 1, Offset |  | 68 |  |  | 68 |  | dB |
| PSRR (Dual Supply) | DC, $\mathrm{G}=1, \pm 5$ to $\pm 15 \mathrm{~V}_{\mathrm{s}}$ |  | 71 |  |  | 71 |  | dB |
| PSRR (Dual Supply) | $\mathrm{DC}, \mathrm{G}=1, \pm 5$ to $\pm 15 \mathrm{~V}_{\mathrm{S}}, \mathrm{T}_{\text {MIN }}-\mathrm{T}_{\mathrm{MAX}}$ | 62 | 68 |  | 60 | 68 |  | dB |

## NOTES

${ }^{1}$ See Standard Military Drawing 5962-9313001MPA for specifications.
${ }^{2}$ Clipping level function on $X$ channel only.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

| Supply Voltage |  |
| :---: | :---: |
| Internal Power Dissipation ${ }^{2}$. . . . . . Observe Derating Curves |  |
| Output Short Circuit Duration . . . . Observe Derating Curves |  |
| Common-Mode Input Voltage |  |
| Differential Input Voltage |  |
| Storage Temperature Range (Q) . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |  |
| Storage Temperature Range (N) . . . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  |
| Storage Temperature Range (R) . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  |
| Operating Temperature Range |  |
| AD830J | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ |
| AD830A | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| AD830S | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
|  | $+300^{\circ} \mathrm{C}$ |

## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2} 8$-Pin Plastic Package: $\theta_{\mathrm{JA}}=90^{\circ} \mathrm{C} / \mathrm{Watt}$
8 -Pin SOIC Package: $\theta_{\mathrm{JA}}=155^{\circ} \mathrm{C} / \mathrm{W}$ att
8 -Pin Cerdip Package: $\theta_{\mathrm{JA}}=110^{\circ} \mathrm{C} / \mathrm{Watt}$

## MAXIMUM POWER DISSIPATION

The maximum power that can be safely dissipated by the AD830 is limited by the associated rise in junction temperature. For the plastic packages, the maximum safe junction temperature is $145^{\circ} \mathrm{C}$. For the cerdip, the maximum junction temperature is $175^{\circ} \mathrm{C}$. If these maximums are exceeded momentarily, proper circuit operation will be restored as soon as the die temperature is reduced. Leaving the AD830 in the "overheated" condition for an extended period can result in permanent damage to the device. To ensure proper operation, it is important to observe the recommended derating curves.
While the AD830 output is internally short circuit protected, this may not be sufficient to guarantee that the maximum junction temperature is not exceeded under all conditions. If the output is shorted to a supply rail for an extended period, then the amplifier may be permanently destroyed.

## ESD SUSCEPTIBILITY

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 volts, which readily accumulate on the human body and on test equipment, can discharge without detection. Although the AD830 features proprietary ESD protection circuitry, permanent damage may still occur on these devices if they are subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid any performance degradation or loss of functionality.

ORDERING GUIDE

| Model | Temperature Range | Package Description | Package Option ${ }^{\mathbf{1}}$ |
| :--- | :--- | :--- | :--- |
| AD830AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic Mini-DIP | N-8 |
| AD830JR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin SOIC | R-8 |
| $5962-9313001 \mathrm{MPA}^{2}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Cerdip | Q-8 |

NOTES
${ }^{1}$ For outline information see Package Information section.
${ }^{2}$ See standard military drawing 5962-9313001MPA.


Maximum Power Dissipation vs. Temperature, Mini-DIP and SOIC Packages


Maximum Power Dissipation vs. Temperature, Cerdip Package


Figure 1. Common-Mode Rejection Ratio vs. Frequency


Figure 2. Harmonic Distortion vs. Frequency


Figure 3. Input Bias Current vs. Temperature


Figure 4. Power Supply Rejection Ratio vs. Frequency


Figure 5. Closed-Loop Gain vs. Frequency $G=+1$


Figure 6. Input Offset Voltage vs. Temperature


Figure 7. Differential Gain and Phase vs. Supply Voltage, $R_{L}=500 \Omega$


Figure 8. Harmonic Distortion vs. Peak Amplitude, Frequency $=100 \mathrm{kHz}$


Figure 9. Noise Spectral Density


Figure 10. Differential Gain and Phase vs. Supply Voltage, $R_{L}=150 \Omega$


Figure 11. Harmonic Distortion vs. Peak Amplitude, Frequency $=4 \mathrm{MHz}$


Figure 12. Supply Current vs. Junction Temperature

## AD830-Typical Characteristics



Figure 13. Closed-Loop Gain vs. Frequency for the Three Common Connections of Figure 16


Figure 14. Small Signal Pulse Response, $R_{L}=150 \Omega$, $C_{L}=4.7 p F, G=+1$


Figure 15. Closed-Loop Gain vs. Frequency vs. $C_{L}$, $G=+1 . V_{S}= \pm 5 V$

(a)

$\mathrm{V}_{\text {OUT }}=\mathrm{V}_{1}$
GAIN OF 1
(c)

Figure 16. Connection Diagrams


Figure 17. Large Signal Pulse Response,


Figure 18. Closed-Loop Gain vs. Frequency, vs. $C_{L}$ $G=+1 . V_{s}= \pm 15 \mathrm{~V}$

## TRADITIONAL DIFFERENTIAL AMPLIFICATION

In the past, when differential amplification was needed to reject common-mode signals superimposed with a desired signal; most often the solution used was the classic op amp based difference amplifier shown in Figure 19. The basic function $\mathrm{V}_{\mathrm{O}}=\mathrm{V}_{1}-\mathrm{V}_{2}$ is simply achieved, but the overall performance is poor and the circuit possesses many serious problems that make it difficult to realize a robust design with moderate to high levels of performance.


Figure 19. Op Amp Based Difference Amplifier
PROBLEMS WITH THE OP AMP BASED APPROACH

- Low Common-Mode Rejection Ratio (CMRR)
- Low Impedance Inputs
- CMRR Highly Sensitive to the Value of Source R
- Different Input Impedance for the + and - Input
- Poor High Frequency CMRR
- Requires Very Highly Matched Resistors $\mathrm{R}_{1}-\mathrm{R}_{4}$ to Achieve High CMRR
- Halves the Bandwidth of the Op Amp
- High Power Dissipation in the Resistors for Large CommonMode Voltage


## AD830 FOR DIFFERENTIAL AMPLIFICATION

The AD830 amplifier was specifically developed to solve the listed problems with the discrete difference amplifier approach. Its topology, discussed in detail in a later section, by design acts as a difference amplifier. The circuit of Figure 20 shows how simply the AD830 is configured to produce the difference of two signals $V_{1}$ and $V_{2}$, in which the applied differential signal is exactly reproduced at the output relative to a separate output common. Any common-mode voltage present at the input is removed by the AD830.


Figure 20. AD830 as a Difference Amplifier

## ADVANTAGEOUS PROPERTIES OF THE AD830

- High Common-Mode Rejection Ratio (CMRR)
- High Impedance Inputs
- Symmetrical Dynamic Response for +1 and -1 Gain
- Low Sensitivity to the Value of Source R
- Equal Input Impedance for the + and - Input
- Excellent High Frequency CMRR
- No Halving of the Bandwidth
- Constant Power Distortion vs. Common-Mode Voltage
- Highly Matched Resistors Not Needed


## UNDERSTANDING THE AD830 TOPOLOGY

The AD830 represents Analog Devices' first amplifier product to embody a powerful alternative amplifier topology. Referred to as active feedback, the topology used in the AD830 provides inherent advantages in the handling of differential signals, differing system commons, level shifting and low distortion, high frequency amplification. In addition, it makes possible the implementation of many functions not realizable with single op amp circuits or is superior to op amp based equivalent circuits. With this in mind, it is important to understand the internal structure of the AD830.
The topology, reduced to its elemental form, is shown below in Figure 21. Nonideal effects such as nonlinearity, bias currents and limited full scale are omitted from this model for simplicity, but are discussed later. The key feature of this topology is the use of two, identical voltage-to-current converters, $\mathrm{G}_{\mathrm{M}}$, that make up input and feedback signal interfaces. They are labeled with inputs $\mathrm{V}_{\mathbf{X}}$ and $\mathrm{V}_{\mathrm{Y}}$, respectively. These voltage to current converters possess fully differential inputs, high linearity, high input impedance and wide voltage range operation. This enables the part to handle large amplitude differential signals; they also provide high common-mode rejection, low distortion and negligible loading on the source. The label, $\mathrm{G}_{\mathrm{M}}$, is meant to convey that the transconductance is a large signal quantity, unlike in the front-end of most op amps. The two $\mathrm{G}_{\mathrm{M}}$ stage current outputs $I_{X}$ and $I_{Y}$, sum together at a high impedance node which is characterized by an equivalent resistance and capacitance connected to an "ac common." A unity voltage gain stage follows the high impedance node to provide buffering from loads. Relative to either input, the open loop gain, $\mathrm{A}_{\mathrm{OL}}$, is set by the transconductance, $\mathrm{G}_{\mathrm{M}}$, working into the resistance, $\mathrm{R}_{\mathrm{P}} ; \mathrm{A}_{\mathrm{OL}}=$ $G_{M} \times R_{P}$. The unity gain frequency $\omega_{0} d B$ for the open loop gain is established by the transconductance, $\mathrm{G}_{\mathrm{M}}$, working into the capacitance, $\mathrm{C}_{\mathrm{C}} ; \omega_{0 \mathrm{~dB}}=\mathrm{G}_{\mathrm{M}} / \mathrm{C}_{\mathrm{C}}$. The open loop description of the AD830 is shown below for completeness.


Figure 21. Topology Diagram


Figure 22. Closed-Loop Connection
Precise amplification is accomplished through closed-loop operation of this topology. Voltage feedback is implemented via the Y $G_{M}$ stage in which where the output is connected to the $-Y$ input for negative feedback as shown in Figure 22. An input signal is applied across the $X G_{M}$ stage, either fully differentially or single-ended referred to common. It produces a current signal which is summed at the high impedance node with the output current from the $Y \mathrm{G}_{\mathrm{M}}$ stage. Negative feedback nulls this sum to a small error current necessary to develop the output voltage at the high impedance node. The error current is usually negligible, so the null condition essentially forces the $Y G_{M}$ output stage current to exactly equal the $X G_{M}$ output current. Since the two transconductances are identical, the differential voltage across the $Y$ inputs equals the negative of the differential voltage across the X input; $\mathrm{V}_{\mathrm{Y}}=-\mathrm{V}_{\mathrm{X}}$ or more precisely $\mathrm{V}_{\mathrm{Y} 2}-\mathrm{V}_{\mathrm{Y} 1}=$ $\mathrm{V}_{\mathrm{X} 1}-\mathrm{V}_{\mathrm{X} 2}$. This simple relation provides the basis to easily analyze any function possible to synthesize with the AD830, including any feedback situation.
The bandwidth of the circuit is defined by the $G_{M}$ and the capacitor $C_{C}$. The highly linear $G_{M}$ stages give the amplifier a single pole response, excluding the output amplifier and loading effects. It is important to note that the bandwidth and general dynamic behavior is symmetrical (identical) for the noninverting and the inverting connections of the AD830. In addition, the input impedance and CMRR are the same for either connections. This is very advantageous and unlike in a voltage or current feedback amplifier, where there is a distinct difference in performance between the inverting and noninverting gain. The practical importance of this cannot be overemphasized and is a key feature offered by the AD830 amplifier topology.

## INTERFACING THE INPUT

## Common-Mode Voltage Range

The common-mode range of the AD830 is defined by the amplitude of the differential input signal and the supply voltage. The general definition of common-mode voltage, $\mathrm{V}_{\mathrm{CM}}$, is usually applied to a symmetrical differential signal centered about a particular voltage as illustrated by the diagram in Figure 23. This is the meaning implied here for common-mode voltage. The internal circuitry establishes the maximum allowable voltage on the input or feedback pins for a given supply voltage. This constraint and the differential input voltage sets the common-mode voltage limit. Figure 24 shows a curve of the common-mode voltage range vs. differential voltage for three supply voltage settings.


Figure 23. Common-Mode Definition


Figure 24. Input Common-Mode Voltage Range vs. Differential Input Voltage

## Differential Voltage Range

The maximum applied differential voltage is limited by the clipping range of the input stages. This is nominally set at 2.4 volts magnitude and depicted in the crossplot ( $\mathrm{X}-\mathrm{Y}$ ) photo of Figure 25. The useful linear range of the input stages is set at 2 volts, but is actually a function of the distortion required for a particular application. The distortion increases for larger differential input voltages. A plot of relative distortion versus input differential voltage is shown in Figures 8 and 11 in the Typical Characteristics section. The distortion characteristics could impose a secondary limit to the differential input voltage for high accuracy applications.


Figure 25. Clipping Behavior


Figure 26. Maximum Output Swing vs. Supply

## Choice of Polarity

The sign of the gain is easily selected by choosing the polarity of the connections to the + and - inputs of the $X G_{M}$ stage. Swapping between inverting and noninverting gain is possible simply by reversing the input connections. The response of the amplifier is identical in either connection, except for the sign change. The bandwidth, high impedance, transient behavior, etc., of the AD830, is symmetrical for both polarities of gain. This is very advantageous and unlike an op amp.

## Input Impedance

The relatively high input impedance of the AD830, for a differential receiver amplifier, permits connections to modest impedance sources without much loading or loss of common-mode rejection. The nominal input resistance is $300 \mathrm{k} \Omega$. The real limit to the upper value of the source resistance is in its effect on common-mode rejection and bandwidth. If the source resistance is in only one input, then the low frequency common-mode rejection will be lowered to $\approx \mathrm{R}_{\mathrm{IN}} / \mathrm{R}_{\mathrm{S}}$. The source resistance/ input capacitance pole ( $\mathrm{f}=\frac{1}{2 \pi} \times \mathrm{R}_{\mathbf{S}} \times \mathrm{C}_{\mathrm{IN}}$ ) limits the bandwidth. Furthermore, the high frequency common-mode rejection will be additionally lowered by the difference in the frequency response caused by the $\mathrm{R}_{\mathrm{S}} \times \mathrm{C}_{\mathrm{IN}}$ pole. Therefore, to maintain good low and high frequency common-mode rejection, it is recommended that the source resistances of the + and inputs be matched and of modest value ( $\leq 10 \mathrm{k} \Omega$ ).

## Handling Bias Currents

The bias currents are typically $4 \mu \mathrm{~A}$ flowing into each pin of the $\mathrm{G}_{\mathrm{M}}$ stages of the AD830. Since all applications possess some finite source resistance, the bias current through this resistor will create a voltage drop ( $\mathrm{I}_{\text {BIAS }} \times \mathrm{R}_{\mathrm{S}}$ ). The relatively high input impedance of the AD830 permits modest values of $R_{S}$, typically $\leq 10 \mathrm{k} \Omega$. If the source resistance is in only one terminal, then an objectional offset voltage may result (e.g., $4 \mu \mathrm{~A} \times 5 \mathrm{k} \Omega=$ $20 \mathrm{mV})$. Placement of an equal value resistor in series with the other input will cancel the offset to first order. However, due to mismatches in the resistances, a residual offset will remain and likely be greater than bias current (offset current) mismatches.

## Applying Feedback

The AD830 is intended for use with gain from 1 to 100 . Gains greater than one are simply set by a pair of resistors connected as shown in the difference amplifier (Figure 35) with gain $>1$. The value of the bottom resistor $\mathrm{R}_{2}$, should be kept less than $1 \mathrm{k} \Omega$ to insure that the pole formed by $\mathrm{C}_{\mathrm{IN}}$ and the parallel connection of $R_{1}$ and $R_{2}$ is sufficiently high in frequency so that it does not introduce excessive phase shift around the loop and destabilizes the amplifier. A compensating resistor, equal to the parallel combination of $R_{1}$ and $R_{2}$, should be placed in series with the other $Y \mathrm{G}_{\mathrm{M}}$ stage input to preserve the high frequency common-mode rejection and to lower the offset voltage induced by the input bias current.

## Output Common Mode

The output swing of the AD830 is defined by the differential input voltage, the gain and the output common. Depending on the anticipated signal span, the output common (or ground) may be set anywhere between the allowable peak output voltage in a manner similar to that described for input voltage common mode. A plot of the peak output voltage versus supply is shown in Figure 26. A prediction of the common-mode range versus
the peak output differential voltage can be easily derived from the maximum output swing as $\mathrm{V}_{\mathrm{OCM}}=\mathrm{V}_{\text {MAX }}-\mathrm{V}_{\text {PEAK }}$.

## Output Current

The absolute peak output current is set by the short circuit current limiting, typically greater that 60 mA . The maximum drive capability is rated at 50 mA , but without a guarantee of distortion performance. Best distortion performance is obtained by keeping the output current $\leq 20 \mathrm{~mA}$. Attempting to drive large voltages into low valued resistances (e.g., 10 V into $150 \Omega$ ) will cause an apparent lowering of the limit for output signal swing, but is just the current limiting behavior.

## Driving Cap Loads

The AD830 is capable of driving modest sized capacitive loads while maintaining its rated performance. Several curves of bandwidth versus capacitive load are given in Figures 15 and 18. The AD830 was designed primarily as a low distortion video speed amplifier, but with a tradeoff, giving up very large capacitive load driving capability. If very large capacitive loads must be driven, then the network shown in Figure 27 should be used to insure stable operation. If the loss of gain caused by the resistor $\mathrm{R}_{\mathrm{S}}$ in series with the load is objectionable, then the optional feedback network shown may be added to restore the lost gain.


Figure 27. Circuit for Driving Large Capacitive Loads


Figure 28. Closed-Loop Response vs. Frequency with 100 pF Load and Series Resistor Compensation

## SUPPLIES, BYPASSING AND GROUNDING (Figure 29)

The AD830 is capable of operating over a wide range of supply voltages, both single and dual supplies. The coupling may be dc or ac provided the input and output voltages stay within the specified common-mode voltage limits. For dual supplies, the device works from $\pm 4 \mathrm{~V}$ to $\pm 16.5 \mathrm{~V}$. Single supply operation is possible over +8 V to +33 V . It is also possible to operate the part with split supply voltages (e.g., $+24 \mathrm{~V},-5 \mathrm{~V}$ ) for special applications such as level shifting. The primary constraint is that the total potential between the two supplies does not exceed 33 V .
Inclusion of power supply bypassing capacitors is necessary to achieve stable behavior and the specified performance. It is especially important when driving low resistance loads. At a minimum, connect a $0.1 \mu \mathrm{~F}$ ceramic capacitor at the supply lead of the AD830 package. In addition, for the best by passing, we recommend connecting a $0.01 \mu \mathrm{~F}$ ceramic capacitor and $4.7 \mu \mathrm{~F}$ tantalum capacitor to the supply lead going to the AD830.


Figure 29. Supply Decoupling Options
The AD830 is designed by its functionality to be capable of rejecting noise and dissimilar potentials in the ground lines. Therefore, proper care is necessary to realize the benefits of the differential amplification of the part. Separation of the input and output grounds is crucial in rejection of the common mode noise at the inputs and eliminating any ground drops on the input signal line. For example, connecting the ground of a coaxial cable to the AD830 output common (board ground) could degrade the CMR and also introduce power-down loading on cable grounds. However, it is also necessary as in any electronic system, to provide a return path for bias currents back to their original power supply. This is accomplished by providing a connection between the differing grounds through a modest impedance labeled $\mathrm{Z}_{\mathrm{CM}}$ (e.g., $100 \Omega$ ).

## Single Supply Operation

The AD830 is capable of operating in single power supply applications down to a voltage of +8 V , with the generalized connection shown in Figure 30. There is a constraint on the commonmode voltage at the input and output which establishes the range for these voltages. Direct coupling may be used for input and output voltages which lie in these ranges. Any gain network applied needs to be referred to the output common connection or have an appropriate offset voltage. In situations where the signal lies at a common voltage outside the common mode range of the AD830 direct coupling will not work, so ac coupling should be used. A tested application included later in this data sheet (Figure 42), shows how to easily accomplish coupling to the AD830. For single supply operation where direct coupling is desired the input and output common-mode curves (Figures 31 and 32 ) should be used.


Figure 30. General Single Supply Connection


Figure 31. Input Common-Mode Range for Single Supply


Figure 32. Output Swing Limit for Single Supply

## Differential Line Receiver

The AD830 was specifically designed to perform as a differential line receiver. The circuit in Figure 33 shows how simple it is to configure the AD830 for this function. The signal from system " $A$ " is received differentially relative to A's common, and that voltage is exactly reproduced relative to the common in system B. The common-mode rejection versus frequency, shown in Figure 1 , is excellent, typically 100 dB at low frequencies. The high input impedance permits the AD 830 to operate as a bridging amplifier across low impedance terminations with negligible loading. The differential gain and phase specifications are very good as shown in Figure 7 for $500 \Omega$ and Figure 10 for $150 \Omega$. The input and output common should be separated to achieve the full CMR performance of the AD830 as a differential amplifier. However, a common return path is necessary between systems A and B.

$\mathrm{v}_{\text {out }}=\mathrm{V}_{1}-\mathrm{V}_{2}$
COMMON IN sYstem b $\nabla$
Figure 33. Differential Line Receiver

## Wide Range Level Shifter

The wide common-mode range and accuracy of the AD830 allows easy level shifting of differential signals referred to an input common-mode voltage to any new voltage defined at the output. The inputs may be referenced to levels as high as 10 V at the inputs with a $\pm 2 \mathrm{~V}$ swing about 10 V . In the circuit of Figure 34, the output voltage, $\mathrm{V}_{\mathrm{OUT}}$, is defined by the simple equation shown below. The excellent linearity and low distortion are preserved over the full input and output common-mode range. The voltage sources need not be of low impedance, since the high input resistance and modest input bias current of the AD830 V-to-I converters permit the use of resistive voltage dividers as reference voltages.


Difference Amplifier with Gain>1
The AD830 can provide instrumentation amplifier style differential amplification at gains greater than 1 . The input signal is connected differentially and the gain is set via feedback resistors as shown in Figure 35. The gain, $G=\left(R_{2}+R_{1}\right) / R_{2}$. The AD830 can provide either inverting or noninverting differential amplification. The polarity of the gain is established by the polarity of the connection at the input. Feedback resistors $\mathbf{R}_{2}$ should generally be $R_{2} \leq 1 \mathrm{k} \Omega$ to maintain closed-loop stability and also keep bias current induced offsets low. Highest CMRR and lowest dc offsets are preserved by including a compensating resistor in series with Pin 3. The gain may be as high as 100.


Figure 35. Gain of $G$ Differential Amplifier, $G>1$

## Offsetting the Output with Gain

Some applications, such as A/D drivers, require that the signal be amplified and also offset, typically to accommodate the input range of the device. The AD830 can offset the output signal very simply through Pin 3 even with gain $>1$. The voltage applied to Pin 3 must be attenuated by an appropriate factor so that $V_{3} \times G=$ desired offset. In Figure 36, a resistive divider from a voltage reference is used to produce the attenuated offset voltage.


Figure 36. Offsetting the Output with Differential Gain >1

Figure 34. Differential Amplification with Level Shifting

Loop Through or Line Bridging Amplifier (Figure 37)
The AD830 is ideally suited for use as a video line bridging amplifier. The video signal is tapped from the conductor of the cable relative to its shield. The high input impedance of the AD830 provides negligible loading on the cable. More significantly, the benign loading is maintained while the AD830 is powered-down. Coupled with its good video load driving performance, the AD830 is well suited to video cable monitoring applications.


Figure 37. Cable Tap Amplifier

## Resistorless Summing

Direct, two input, resistorless summing is easily realized from the general unity gain mode. By grounding $\mathrm{V}_{\mathrm{x} 2}$ and applying the two inputs to $\mathrm{V}_{\mathrm{X} 1}$ and $\mathrm{V}_{\mathrm{Y} 1}$, the output is the exact sum of the applied voltages $V_{1}$ and $V_{3}$, relative to common; $V_{\text {OUT }}=V_{1}$ $+\mathrm{V}_{3}$. A diagram of this simple, but potent application is shown below in Figure 38. The AD830 summing circuit possesses several virtues not present in the classic op amp based summing circuits. It has high impedance inputs, no resistors, very precise summing, high reverse isolation and noninverting gain. Achieving this function and performance with op amps requires significantly more components.


Figure 38. Resistorless Summing Amplifier

## $2 \times$ Gain Bandwidth Line Driver

A gain of two, without the use of resistors, is possible with the AD830. This is accomplished by grounding $\mathrm{V}_{\mathrm{x} 2}$, tying the two inputs $\mathrm{V}_{\mathrm{X} 1}$ and $\mathrm{V}_{\mathrm{Y} 1}$ together and applying the input, $\mathrm{V}_{\mathrm{IN}}$, to
this wired connection. The output is exactly twice the applied voltage, $\mathrm{V}_{\mathrm{IN}} ; \mathrm{V}_{\mathrm{OUT}}=2 \times \mathrm{V}_{\mathrm{IN}}$. Figure 39 below shows the connections for this highly useful application. The most notable characteristic of this alternative gain of two is that there is no loss of bandwidth as in a voltage feedback op amp based gain of +2 where the bandwidth is halved, therefore, the gain bandwidth is doubled. Also, this circuit is accurate without the need for any precise valued resistors, as in the op amp equivalents, and it possess excellent differential gain and phase performance as shown in Figures 40 and 41.


Figure 39. Full Bandwidth Line Driver $(G=+2)$


Figure 40. Differential Gain and Phase for the Circuit of Figure 39


Figure 41. 0.1 dB Gain Flatness for the Circuit of Figure 39

## AC COUPLED LINE RECEIVER

The AD830 is configurable as an ac coupled differential amplifier on a single or bipolar supply voltages. All that is needed is inclusion of a few noncritical passive components as illustrated below in Figure 42. A simple resistive network at the $\mathrm{X} \mathrm{G}_{M}$ input establishes a common-mode bias. Here, the common mode is centered at 6 volts, but in principle can be any voltage within the common-mode limits of the AD830. The $10 \mathrm{k} \Omega$ resistors to each input bias the $X G_{M}$ stage with sufficiently high impedance to keep the input coupling corner frequency low, but not too large so that residual bias current induced offset voltage becomes troublesome. For dual supply operation, the $10 \mathrm{k} \Omega$
resistors may go directly to ground. The output common is conveniently set by a Zener diode for a low impedance reference to preserve the high frequency CMR. However, a simple resistive divider will work fine and good high frequency CMR can be maintained by placing a compensating resistor in series with the +Y input. The excellent CMRR response of the circuit is shown in Figure 43. A plot of the 0.1 dB flatness from 10 Hz is also shown. With the use of $10 \mu \mathrm{~F}$ capacitors, the CMR is $>90 \mathrm{~dB}$ down to a few tens of hertz. This level of performance is almost impossible to achieve with discrete solutions.


Figure 42. AC Coupled Line Receiver


Figure 43. Common-Mode Rejection vs. Frequency for Line Receiver


Figure 44. Amplitude Response vs. Frequency for Line Receiver

## FEATURES

Wideband AC Performance
Gain Bandwidth Product: $\mathbf{4 0 0} \mathbf{~ M H z}$ (Gain $\geq 10$ )
Fast Settling: 100 ns to $\mathbf{0 . 0 1 \%}$ for a 10 V Step
Slew Rate: $400 \mathrm{~V} / \mu \mathrm{s}$
Stable at Gains of 10 or Greater
Full Power Bandwidth: 6.4 MHz for 20 V p-p into a $500 \Omega$ Load
Precision DC Performance
Input Offset Voltage: $0.3 \mathbf{m V}$ max
Input Offset Drift: $\mathbf{3 \mu V} /{ }^{\circ} \mathrm{C}$ typ
Input Voltage Noise: $4 \mathrm{nV} / \sqrt{\mathrm{Hz}}$
Open-Loop Gain: $130 \mathrm{~V} / \mathrm{mV}$ into a $1 \mathrm{k} \Omega$ Load
Output Current: $\mathbf{5 0} \mathrm{mA}$ min
Supply Current: 12 mA max

## APPLICATIONS

Video and Pulse Amplifiers
DAC and ADC Buffers
Line Drivers
Available in 14-Pin Plastic DIP, Hermetic Cerdip and 20-Pin LCC Packages and in Chip Form
MIL-STD-883B Processing Available

## PRODUCT DESCRIPTION

The AD840 is a member of the Analog Devices' family of wide bandwidth operational amplifiers. This high speed/high precision family includes, among others, the AD841, which is unity-gain stable, and the AD842, which is stable at a gain of two or greater and has 100 mA minimum output current drive. These devices are fabricated using Analog Devices' junction isolated complementary bipolar (CB) process. This process permits a combination of dc precision and wideband ac performance previously unobtainable in a monolithic op amp. In addition to its 400 MHz gain bandwidth product, the AD840 offers extremely fast settling characteristics, typically settling to within $0.01 \%$ of final value in 100 ns for a 10 volt step.

The AD840 remains stable over its full operating temperature range at closed-loop gains of 10 or greater. It also offers a low quiescent current of 12 mA maximum, a minimum output current drive capability of 50 mA , a low input voltage noise of $4 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ and a low input offset voltage of 0.3 mV maximum (AD840K).
The $400 \mathrm{~V} / \mu \mathrm{s}$ slew rate of the AD840, along with its 400 MHz gain bandwidth, ensures excellent performance in video and pulse amplifier applications. This amplifier is ideally suited for use in high frequency signal conditioning circuits and wide

## CONNECTION DIAGRAMS


bandwidth active filters. The extremely rapid settling time of the AD840 makes it the preferred choice for data acquisition applications which require 12 -bit accuracy. The AD840 is also appropriate for other applications such as high speed DAC and ADC buffer amplifiers and other wide bandwidth circuitry.

## APPLICATION HIGHLIGHTS

1. The high slew rate and fast settling time of the AD840 make it ideal for DAC and ADC buffers, line drivers and all types of video instrumentation circuitry.
2. The AD840 is truly a precision amplifier. It offers 12 -bit accuracy to $0.01 \%$ or better and wide bandwidth, performance previously available only in hybrids.
3. The AD840's thermally balanced layout and the high speed of the CB process allow the AD840 to settle to $0.01 \%$ in 100 ns without the long "tails" that occur with other fast op amps.
4. Laser wafer trimming reduces the input offset voltage to 0.3 mV max on the K grade, thus eliminating the need for external offset nulling in many applications. Offset null pins are provided for additional versatility.
5. Full differential inputs provide outstanding performance in all standard high frequency op amp applications where circuit gain will be 10 or greater.
6. The AD840 is an enhanced replacement for the HA2540.
[^147]AD840-SPECIFICATIONS
(@ $+25^{\circ} \mathrm{C}$ and $\pm 15 \mathrm{~V}$ dc, unless otherwise noted)

| Model |  |  | D840J |  |  | D840K |  |  | D840S |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Conditions | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | Units |
| INPUT OFFSET VOLTAGE ${ }^{1}$ Offset Drift | $\mathrm{T}_{\text {min }}-\mathrm{T}_{\text {max }}$ |  |  | $\begin{aligned} & 1 \\ & 1.5 \end{aligned}$ |  | $\begin{aligned} & 0.1 \\ & 3 \end{aligned}$ | $\begin{aligned} & 0.3 \\ & 0.7 \end{aligned}$ |  |  | $\begin{aligned} & \mathbf{1} \\ & 2 \end{aligned}$ | mV <br> mV <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| INPUT BIAS CURRENT | $\mathrm{T}_{\text {min }}-\mathrm{T}_{\text {max }}$ |  | 3.5 | $\begin{aligned} & 8 \\ & 10 \end{aligned}$ |  | 3.5 | 5 |  |  | $\begin{aligned} & 8 \\ & 12 \end{aligned}$ | $\mu \mathrm{A}$ |
| INPUT OFFSET CURRENT | $\mathrm{T}_{\text {min }}-\mathrm{T}_{\text {max }}$ |  | 0.1 | $\begin{aligned} & 0.4 \\ & 0.5 \end{aligned}$ |  | 0.1 | $\begin{aligned} & 0.2 \\ & 0.3 \end{aligned}$ |  |  | $\begin{aligned} & 0.4 \\ & 0.6 \end{aligned}$ | $\begin{aligned} & \mu \mathrm{A} \\ & \mu \mathrm{~A} \end{aligned}$ |
| INPUT CHARACTERISTICS <br> Input Resistance Input Capacitance | Differential Mode |  | $\begin{aligned} & 30 \\ & 2 \end{aligned}$ |  |  | $\begin{aligned} & 30 \\ & 2 \end{aligned}$ |  |  | $\begin{aligned} & 30 \\ & 2 \end{aligned}$ |  | $\begin{aligned} & \mathrm{k} \Omega \\ & \mathrm{pF} \end{aligned}$ |
| INPUT VOLTAGE RANGE <br> Common Mode Common-Mode Rejection | $\begin{aligned} & \mathrm{V}_{\mathrm{CM}}= \pm 10 \mathrm{~V} \\ & \mathrm{~T}_{\min }-\mathrm{T}_{\max } \end{aligned}$ | $\begin{aligned} & \pm \mathbf{1 0} \\ & \mathbf{9 0} \\ & 85 \end{aligned}$ | $\begin{aligned} & 12 \\ & 110 \end{aligned}$ |  | $\begin{aligned} & \pm 10 \\ & 106 \\ & 90 \end{aligned}$ | $\begin{aligned} & 12 \\ & 115 \end{aligned}$ |  | $\begin{aligned} & \pm 10 \\ & 90 \\ & 85 \end{aligned}$ | $\begin{aligned} & 12 \\ & 110 \end{aligned}$ |  | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \end{aligned}$ |
| INPUT VOLTAGE NOISE Wideband Noise | $\begin{aligned} & \mathbf{f}=1 \mathrm{kHz} \\ & 10 \mathrm{~Hz} \text { to } 10 \mathrm{MHz} \end{aligned}$ |  | $\begin{aligned} & \hline 4 \\ & 10 \end{aligned}$ |  |  | $\begin{aligned} & 4 \\ & 10 \end{aligned}$ |  |  | $\begin{aligned} & 4 \\ & 10 \end{aligned}$ |  | $\begin{aligned} & \mathrm{nV} / \sqrt{\mathrm{Hz}} \\ & \mu \mathrm{~V} \mathrm{rms} \end{aligned}$ |
| OPEN-LOOP GAIN | $\begin{aligned} & \mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{LOAD}}=1 \mathrm{k} \Omega \\ & \mathrm{~T}_{\min }-\mathrm{T}_{\max } \\ & \mathrm{R}_{\mathrm{LOAD}}=500 \Omega \\ & \mathrm{~T}_{\min }-\mathrm{T}_{\max } \end{aligned}$ | $\begin{aligned} & 100 \\ & 50 \\ & 75 \\ & 50 \end{aligned}$ | $\begin{aligned} & 130 \\ & 80 \end{aligned}$ |  | $\begin{aligned} & 100 \\ & 75 \\ & 100 \\ & 75 \end{aligned}$ | $\begin{aligned} & 130 \\ & 100 \end{aligned}$ |  | $\begin{aligned} & \mathbf{1 0 0} \\ & \mathbf{5 0} \\ & 75 \\ & 50 \end{aligned}$ | $\begin{aligned} & 130 \\ & 80 \end{aligned}$ |  | $\mathrm{V} / \mathrm{mV}$ <br> $\mathrm{V} / \mathrm{mV}$ <br> $\mathrm{V} / \mathrm{mV}$ <br> $\mathrm{V} / \mathrm{mV}$ |
| OUTPUT CHARACTERISTICS <br> Voltage <br> Current <br> Output Resistance | $\begin{aligned} & \mathrm{R}_{\text {LOAD }} \geq 500 \Omega \\ & \mathrm{~T}_{\min }-\mathrm{T}_{\max } \\ & \mathrm{V}_{\text {OUT }} \pm 10 \mathrm{~V} \\ & \text { Open Loop } \end{aligned}$ | $\begin{aligned} & \mathbf{1 0} \\ & \mathbf{5 0} \end{aligned}$ | 15 |  | $\begin{aligned} & \pm 10 \\ & 50 \end{aligned}$ | 15 |  | $\begin{aligned} & \pm 10 \\ & \mathbf{5 0} \end{aligned}$ | 15 | \% | V <br> mA <br> $\Omega$ |
| FREQUENCY RESPONSE <br> Gain Bandwidth Product <br> Full Power Bandwidth ${ }^{2}$ <br> Rise Time <br> Overshoot ${ }^{3}$ <br> Slew Rate ${ }^{3}$ <br> Settling Time ${ }^{3}-10 \mathrm{~V}$ Step | $\begin{aligned} & \mathrm{V}_{\mathrm{OUT}}=90 \mathrm{mV} \mathrm{p}-\mathrm{p} \\ & \mathrm{~A}_{\mathrm{v}}=-10 \\ & \mathrm{~V}_{\mathrm{O}}=20 \mathrm{~V} \text { p-p } \\ & \mathrm{R}_{\mathrm{LOAD}} \geq 500 \Omega \\ & \mathrm{~A}_{\mathrm{v}}=-10 \\ & \mathrm{~A}_{\mathrm{v}}=-10 \\ & \mathrm{~A}_{\mathrm{v}}=-10 \\ & \mathrm{~A}_{\mathrm{v}}=-10 \\ & \text { to } 0.1 \% \\ & \text { to } 0.01 \% \end{aligned}$ | 5.5 350 | $\begin{aligned} & 400 \\ & 6.4 \\ & 10 \\ & 20 \\ & 400 \\ & \\ & 80 \\ & 100 \end{aligned}$ |  | 5.5 350 | $\begin{aligned} & 400 \\ & 6.4 \\ & 10 \\ & 20 \\ & 400 \\ & \\ & 80 \\ & 100 \end{aligned}$ |  | $5.5$ $350$ | $\begin{aligned} & 400 \\ & \\ & 6.4 \\ & 10 \\ & 20 \\ & 400 \\ & \\ & 80 \\ & 100 \end{aligned}$ |  | MHz <br> MHz <br> ns <br> \% <br> $\mathrm{V} / \mu \mathrm{s}$ <br> ns <br> ns |
| OVERDRIVE RECOVERY | -Overdrive <br> +Overdrive |  | $\begin{aligned} & 190 \\ & 350 \end{aligned}$ |  |  | $\begin{aligned} & 190 \\ & 350 \end{aligned}$ |  |  | $\begin{aligned} & 190 \\ & 350 \end{aligned}$ |  | $\begin{aligned} & \text { ns } \\ & \text { ns } \end{aligned}$ |
| DIFFERENTIAL GAIN | $\mathrm{f}=4.4 \mathrm{MHz}$ |  | 0.025 |  |  | 0.025 |  |  | 0.025 |  | \% |
| DIFFERENTIAL PHASE | $\mathrm{f}=4.4 \mathrm{MHz}$ |  | 0.04 |  |  | 0.04 |  |  | 0.04 |  | Degree |
| POWER SUPPLY <br> Rated Performance <br> Operating Range <br> Quiescent Current <br> Power Supply Rejection Ratio | $\begin{aligned} & \mathrm{T}_{\min }-\mathrm{T}_{\max } \\ & \mathrm{V}_{\mathrm{S}}= \pm 5 \mathrm{~V} \text { to } \pm 18 \mathrm{~V} \\ & \mathrm{~T}_{\min }-\mathrm{T}_{\max } \end{aligned}$ | $\begin{aligned} & \pm 5 \\ & 90 \\ & 80 \end{aligned}$ | $\begin{aligned} & \pm 15 \\ & 12 \\ & 100 \end{aligned}$ | $\begin{aligned} & \pm 18 \\ & 14 \\ & 16 \end{aligned}$ | $\begin{aligned} & \pm 5 \\ & 94 \\ & 86 \end{aligned}$ | $\begin{aligned} & \pm 15 \\ & 12 \\ & 100 \end{aligned}$ | $\begin{aligned} & \pm 18 \\ & 14 \\ & 16 \end{aligned}$ | $\begin{aligned} & \pm 5 \\ & 90 \\ & 80 \end{aligned}$ | $\begin{aligned} & \pm 15 \\ & 12 \\ & 100 \end{aligned}$ | $\begin{aligned} & \pm 18 \\ & 14 \\ & 18 \end{aligned}$ | V V mA mA dB dB |
| TEMPERATURE RANGE Rated Performance ${ }^{4}$ |  | 0 |  | +75 | 0 |  | +75 | -55 |  | +125 | ${ }^{\circ} \mathrm{C}$ |
| TRANSISTOR COUNT | \# of Transistors |  | 72 |  |  | 72 |  |  | 72 |  |  |

NOTES
${ }^{1}$ Input offset voltage specifications are guaranteed after 5 minutes at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.
${ }^{2}$ Full power bandwidth $=$ slew rate $/ 2 \pi \mathrm{~V}_{\text {PEAK }}$.
${ }^{3}$ Refer to Figures 22 and 23.
${ }^{4}$ " S " grade $\mathrm{T}_{\text {min }}-\mathrm{T}_{\text {max }}$ specifications are tested with automatic test equipment at $\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ and $\mathrm{T}_{\mathrm{A}}=+125^{\circ} \mathrm{C}$.
All min and max specifications are guaranteed. Specifications shown in boldface are tested on all production units.
Specifications subject to change without notice.

| ABSOLUTE MAXIMUM RATINGS ${ }^{1}$ |  |  |  |
| :---: | :---: | :---: | :---: |
| ABSOLUTE MAXIMUM RATINGS |  |  |  |
| Internal Power Dissipation ${ }^{2}$ |  |  |  |
| Plastic (N) |  |  |  |
| Cerdip (Q) |  |  |  |
| LCC (E) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 1.0 W |  |  |  |
| Input Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm \mathrm{V}_{\text {S }}$ |  |  |  |
| Differential Input Voltage . . . . . . . . . . . . . . . . . . . . . $\pm 6$ V |  |  |  |
| Storage Temperature Range |  |  |  |
| Q, E . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |  |  |  |
| N . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  |  |  |
| Junction Temperature ( $\mathrm{T}_{\mathrm{J}}$ ) . . . . . . . . . . . . . . . . . . $+175^{\circ} \mathrm{C}$ |  |  |  |
| Lead Temperature Range (Soldering 60 sec ) . . . . . . $+300^{\circ} \mathrm{C}$ |  |  |  |
| NOTES |  |  |  |
| ${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. |  |  |  |
| ${ }^{2}$ Maximum internal power dissipation is specified so that $T_{J}$ does not exceed $+175^{\circ} \mathrm{C}$ at an ambient temperature of $+25^{\circ} \mathrm{C}$. |  |  |  |
| Thermal Characteristics: |  |  |  |
|  | $\theta_{\text {JC }}$ | $\theta_{\text {JA }}$ | Derate at |
| Cerdip Package | $30^{\circ} \mathrm{C} / \mathrm{W}$ | $110^{\circ} \mathrm{C} / \mathrm{W}$ | $8.7 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ |
| Plastic Package | $30^{\circ} \mathrm{C} / \mathrm{W}$ | $100^{\circ} \mathrm{C} / \mathrm{W}$ | $10 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ |
| LCC Package | $35^{\circ} \mathrm{C} / \mathrm{W}$ | $150^{\circ} \mathrm{C} / \mathrm{W}$ | $6.7 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ |

Recommended Heat Sink:
Aavid Engineering ${ }^{\circledR}$ \#602B

## ORDERING GUIDE

| Model $^{\mathbf{1}}$ | Package Options |
| :--- | :--- |
| AD840JN | $\mathrm{N}-14$ |
| AD840KN | $\mathrm{N}-14$ |
| AD840JQ | $\mathrm{Q}-14$ |
| AD840KQ | Q-14 |
| AD840SQ | Q-14 |
| AD840SQ-883B | Q-14 |
| 5962-89640012A | Q-14 |
| AD840SE-883B | E-20A |
| 5962-8964001CA | E-20A |

## NOTES

${ }^{1} \mathrm{~J}$ and S Grade Chips also available.
${ }^{2} \mathrm{~N}=$ Plastic DIP; $\mathrm{Q}=$ Cerdip; $\mathrm{E}=\mathrm{LCC}$ (Leadless Ceramic Chip Carrier). For outline information see Package Information section.


AD840 Connection Diagrams

## METALIZATION PHOTOGRAPH

Contact factory for latest dimensions.
Dimensions shown in inches and (mm).


## FEATURES

AC PERFORMANCE
Unity-Gain Bandwidth: $\mathbf{4 0} \mathbf{~ M H z}$
Fast Settling: 110 ns to 0.01\%
Slew Rate: $300 \mathrm{~V} / \mu \mathrm{s}$
Full Power Bandwidth: 4.7 MHz for 20 V p-p into a $500 \Omega$ Load

## DC PERFORMANCE

Input Offset Voltage: $1 \mathbf{m V}$ max
Input Voltage Noise: $13 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ typ
Open-Loop Gain: $45 \mathrm{~V} / \mathrm{mV}$ into a $1 \mathrm{k} \Omega$ Load
Output Current: 50 mA min
Supply Current: 12 mA max

## APPLICATIONS

High Speed Signal Conditioning
Video and Pulse Amplifiers
Data Acquisition Systems

## Line Drivers

## Active Filters

Available in 14-Pin Plastic DIP, Hermetic Cerdip, 12-Pin TO-8 Metal Can and 20-Pin LCC Packages
Chips and MIL-STD-883B Parts Available

## PRODUCT DESCRIPTION

The AD841 is a member of the Analog Devices family of wide bandwidth operational amplifiers. This high speed/high precision family includes, among others, the AD840, which is stable at a gain of 10 or greater, and the AD842, which is stable at a gain of two or greater and has 100 mA minimum output current drive. These devices are fabricated using Analog Devices' junction isolated complementary bipolar (CB) process. This process permits a combination of dc precision and wideband ac performance previously unobtainable in a monolithic op amp. In addition to its 40 MHz unity-gain bandwidth product, the AD841 offers extremely fast settling characteristics, typically settling to within $0.01 \%$ of final value in 110 ns for a 10 volt step.

Unlike many high frequency amplifiers, the AD841 requires no external compensation. It remains stable over its full operating temperature range. It also offers a low quiescent current of 12 mA maximum, a minimum output current drive capability of 50 mA , a low input voltage noise of $13 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ and low input offset voltage of 1 mV maximum.

The $300 \mathrm{~V} / \mu \mathrm{s}$ slew rate of the AD841, along with its 40 MHz gain bandwidth, ensures excellent performance in video and pulse amplifier applications. This amplifier is well suited for use in high frequency signal conditioning circuits and wide bandwidth active filters. The extremely rapid settling time of the AD841 makes it the preferred choice for data acquisition applications which require 12-bit accuracy. The AD841 is also appropriate for other applications such as high speed DAC and ADC buffer amplifiers and other wide bandwidth circuitry.

## CONNECTION DIAGRAMS




## APPLICATION HIGHLIGHTS

1. The high slew rate and fast settling time of the AD841 make it ideal for DAC and ADC buffers, and all types of video instrumentation circuitry.
2. The AD841 is a precision amplifier. It offers accuracy to $0.01 \%$ or better and wide bandwidth performance previously available only in hybrids.
3. The AD841's thermally balanced layout and the speed of the CB process allow the AD841 to settle to $0.01 \%$ in 110 ns without the long "tails" that occur with other fast op amps.
4. Laser wafer trimming reduces the input offset voltage to 1 mV max on the K grade, thus eliminating the need for external offset nulling in many applications. Offset null pins are provided for additional versatility.
5. The AD841 is an enhanced replacement for the HA2541.

[^148]

## NOTES

${ }^{1}$ Standard Military Drawing Available: 5962-89641012A - (SE/883B); 5962-8964101CA - (SQ/883B)
${ }^{2}$ Input offset voltage specifications are guaranteed after 5 minutes at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.
${ }^{3}$ Full power bandwidth $=$ Slew Rate $/ 2 \pi \mathrm{~V}_{\text {PEAK }}$.
${ }^{4}$ Refer to Figure 19.
s" S " grade $\mathrm{T}_{\text {min }}$ and $\mathrm{T}_{\text {max }}$ specifications are tested with automatic test equipment at $\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ and $\mathrm{T}_{\mathrm{A}}=+125^{\circ} \mathrm{C}$.
${ }^{6}$ For outline information see Package Information section.
All min and max specifications are guaranteed. Specifications shown in boldface are tested on all production units.
Specifications subject to change without notice.

| ABSOLUTE MAXIMUM RATINGS ${ }^{1}$ |  |
| :---: | :---: |
| Supply Voltage | $\pm 18 \mathrm{~V}$ |
| Internal Power Dissipation ${ }^{2}$ |  |
| TO-8 (H) | 1.4 W |
| Plastic (N) | 1.5 W |
| Cerdip (Q) | 1.3 W |
| Input Voltage . . . . . . . . . . . . . . . . . . . . . . . . $\pm \mathrm{V}_{\text {s }}$ |  |
| Differential Input Voltage . . . . . . . . . . . . . . . . . . . . $\pm 6 \mathrm{~V}$ |  |
| Storage Temperature Range |  |
| Q, H, E | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| N | $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Junction Temperature | $+175^{\circ} \mathrm{C}$ |
| Lead Temperature Range (Soldering 60 sec ) | $+300^{\circ} \mathrm{C}$ |

## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ Maximum internal power dissipation is specified so that $T_{J}$ does not exceed $+175^{\circ} \mathrm{C}$ at an ambient temperature of $+25^{\circ} \mathrm{C}$.

Thermal Characteristics:

|  | $\theta_{\mathrm{JC}}$ | $\theta_{\mathrm{JA}}$ | $\theta_{\mathrm{SA}}$ |  |
| :--- | :--- | :--- | :--- | :--- |
| Cerdip Package | $35^{\circ} \mathrm{C} / \mathrm{W}$ | $110^{\circ} \mathrm{C} / \mathrm{W}$ | $38^{\circ} \mathrm{C} / \mathrm{W}$ | Recommended Heat Sink: |
| TO-8 Package | $30^{\circ} \mathrm{C} / \mathrm{W}$ | $100^{\circ} \mathrm{C} / \mathrm{W}$ | $37^{\circ} \mathrm{C} / \mathrm{W}$ | Aavid Engineering ${ }^{\circ} \# 602 \mathrm{~B}$ |
| Plastic Package | $30^{\circ} \mathrm{C} / \mathrm{W}$ | $100^{\circ} \mathrm{C} / \mathrm{W}$ |  |  |
| LCC Package | $35^{\circ} \mathrm{C} / \mathrm{W}$ | $150^{\circ} \mathrm{C} / \mathrm{W}$ |  |  |

## METALIZATION PHOTOGRAPH

Contact factory for latest dimensions.
Dimensions shown in inches and (mm).


## FEATURES

## AC PERFORMANCE

$$
\text { Gain Bandwidth Product: } 80 \mathrm{MHz}(\text { Gain }=2)
$$

Fast Settling: 100 ns to $\mathbf{0 . 0 1 \%}$ for a 10 V Step
Slew Rate: 375 V/ $\mu \mathrm{s}$
Stable at Gains of 2 or Greater
Full Power Bandwidth: $\mathbf{6 . 0} \mathbf{~ M H z}$ for 20 V p-p

## DC PERFORMANCE

Input Offset Voltage: $1 \mathbf{m V}$ max
Input Offset Drift: $14 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$
Input Voltage Noise: $\mathbf{9 n V} / \sqrt{\mathbf{H z}}$ typ
Open-Loop Gain: $\mathbf{9 0} \mathrm{V} / \mathrm{mV}$ into a $\mathbf{5 0 0} \boldsymbol{\Omega}$ Load
Output Current: 100 mA min
Quiescent Supply Current: 14 mA max
APPLICATIONS
Line Drivers
DAC and ADC Buffers
Video and Pulse Amplifiers
Available in Plastic DIP, Hermetic Metal Can, Hermetic Cerdip, SOIC and LCC Packages and in Chip Form

## MIL-STD-883B Parts Available

Available in Tape and Reel in Accordance with EIA-481A Standard

## PRODUCT DESCRIPTION

The AD842 is a member of the Analog Devices family of wide bandwidth operational amplifiers. This family includes, among others, the AD840 which is stable at a gain of 10 or greater and the AD841 which is unity-gain stable. These devices are fabricated using Analog Devices' junction isolated complementary bipolar (CB) process. This process permits a combination of dc precision and wideband ac performance previously unobtainable in a monolithic op amp. In addition to its 80 MHz gain bandwidth, the AD842 offers extremely fast settling characteristics, typically settling to within $0.01 \%$ of final value in less than 100 ns for a 10 volt step.
The AD842 also offers a low quiescent current of 13 mA , a high output current drive capability ( 100 mA minimum), a low input voltage noise of $9 \mathrm{nV} \sqrt{\mathrm{Hz}}$ and a low input offset voltage ( 1 mV maximum).
The $375 \mathrm{~V} / \mu \mathrm{s}$ slew rate of the AD842, along with its 80 MHz gain bandwidth, ensures excellent performance in video and pulse amplifier applications. This amplifier is ideally suited for use in high frequency signal conditioning circuits and wide bandwidth active filters. The extremely rapid settling time of the AD842 makes this amplifier the preferred choice for data acquisition applications which require 12 -bit accuracy. The AD842 is also appropriate for other applications such as high speed DAC and ADC buffer amplifiers and other wide bandwidth circuitry.

## CONNECTION DIAGRAMS



## APPLICATION HIGHLIGHTS

1. The high slew rate and fast settling time of the AD842 make it ideal for DAC and ADC buffers amplifiers, lines drivers and all types of video instrumentation circuitry.
2. The AD842 is a precision amplifier. It offers accuracy to $0.01 \%$ or better and wide bandwidth; performance previously available only in hybrids.
3. Laser-wafer trimming reduces the input offset voltage of 1 mV max, thus eliminating the need for external offset nulling in many applications.
4. Full differential inputs provide outstanding performance in all standard high frequency op amp applications where the circuit gain will be 2 or greater.
5. The AD842 is an enhanced replacement for the HA2542.
[^149]
## AD842-SPECIFICATIONS <br> (@ $+25^{\circ} \mathrm{C}$ and $\pm 15 \mathrm{Vdc}$, unless otherwise noted)



## NOTES

${ }^{1}$ AD842JR specifications differ from those of the AD842JN, JQ and JH due to the thermal characteristics of the SOIC package.
${ }^{2}$ Standard Military Drawing available 5962-8964201xx
$2 \mathrm{~A}-(\mathrm{SE} / 883 \mathrm{~B})$; XA - (SH/883B); CA - (SQ/883B).
${ }^{3}$ Input offset voltage specifications are guaranteed after 5 minutes at $T_{A}=+25^{\circ} \mathrm{C}$.
${ }^{4}$ FPBW Slew Rate $/ 2 \pi \mathrm{~V}_{\text {PEAK }}$.
${ }^{5}$ Refer to Figures 22 and 23.
${ }^{6 \times \prime}$ " $\mathrm{S}^{\prime}$ grade $\mathrm{T}_{\text {min }}$ and $\mathrm{T}_{\text {max }}$ specifications are tested with automatic test equipment at $\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ and $\mathrm{T}_{\mathrm{A}}=+125^{\circ} \mathrm{C}$.
${ }^{7}$ For outline information see Package Information section.
All min and max specifications are guaranteed. Specifications in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels.
Specifications subject to change without notice.
ABSOLUTE MAXIMUM RATINGS ${ }^{1}$
Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 18$ V
Internal Power Dissipation ${ }^{2}$
Plastic (N) ..... 1.3 W
Cerdip (Q) ..... 1.1 W
TO-8 (H) ..... 1.3 W
SOIC (R) ..... 1.3 W
LCC (E) ..... 1.0 W
Input Voltage ..... $\pm V_{S}$
Differential Input Voltage ..... $\pm 6 \mathrm{~V}$
Storage Temperature Range
(Q, H, E) $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
( $\mathrm{N}, \mathrm{R}$ ) ..... $+125^{\circ} \mathrm{C}$
Junction Temperature ..... $+175^{\circ} \mathrm{C}$
Lead Temperature Range (Soldering 60 sec ) ..... $+300^{\circ} \mathrm{C}$

## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ Maximum internal power dissipation is specified so that $T_{J}$ does not exceed $+150^{\circ} \mathrm{C}$ at an ambient temperature of $+25^{\circ} \mathrm{C}$.

Thermal Characteristics:

|  | $\theta_{\mathrm{J}} \mathrm{C}$ | $\theta_{\mathrm{JA}}$ | $\theta_{\mathrm{SA}}$ |
| :--- | :--- | :--- | :--- |
| Plastic Package | $30^{\circ} \mathrm{C} / \mathrm{W}$ | $100^{\circ} \mathrm{C} / \mathrm{W}$ |  |
| Cerdip Package | $30^{\circ} \mathrm{C} / \mathrm{W}$ | $110^{\circ} \mathrm{C} / \mathrm{W}$ | $38^{\circ} \mathrm{C} / \mathrm{W}$ |
| TO-8 Package | $30^{\circ} \mathrm{C} / \mathrm{W}$ | $100^{\circ} \mathrm{C} / \mathrm{W}$ | $27^{\circ} \mathrm{C} / \mathrm{W}$ |
| 16-Pin SOIC Package | $30^{\circ} \mathrm{C} / \mathrm{W}$ | $100^{\circ} \mathrm{C} / \mathrm{W}$ |  |
| 20-Pin LCC Package | $35^{\circ} \mathrm{C} / \mathrm{W}$ | $150^{\circ} \mathrm{C} / \mathrm{W}$ |  |

Recommended heat sink: Aavid Engineering ${ }^{\bullet}$ \#602B

## METALIZATION PHOTOGRAPH

Contact factory for latest dimensions.
Dimensions shown in inches and (mm).


34 MHz , CBFET Fast Settling Op Amp

## FEATURES

ac PERFORMANCE
Unity Gain Bandwidth: $\mathbf{3 4} \mathbf{~ M H z}$
Fast Settling: 135 ns to $\mathbf{0 . 0 1 \%}$
Slew Rate: 250 V/ $\mu \mathrm{s}$
Stable at Gains of 1 or Greater
Full Power Bandwidth: 3.9 MHz
DC PERFORMANCE
Input Offset Voltage: $1 \mathbf{m V} \max (A D 843 K / B)$
Input Bias Current: 0.6 nA typ
Input Voltage Noise: $19 \mathrm{nV} / \sqrt{\mathrm{Hz}}$
Open Loop Gain: $\mathbf{3 0} \mathrm{V} / \mathrm{mV}$ into a $500 \Omega$ Load
Output Current: $\mathbf{5 0} \mathrm{mA}$ min
Supply Current: 13 mA max
Available in 8 -Pin Plastic Mini-DIP \& Cerdip, 16-Pin SOIC, 20-Pin LCC and 12-Pin Hermetic Metal Can Packages
Available in Tape and Reel in Accordance with EIA-481A Standard
Chips and MIL-STD-883B Parts Also Available
APPLICATIONS
High Speed Sample-and-Hold Amplifiers
High Bandwidth Active Filters
High Speed Integrators
High Frequency Signal Conditioning

## PRODUCT DESCRIPTION

The AD843 is a fast settling, 34 MHz , CBFET input op amp.
The AD843 combines the low ( 0.6 nA ) input bias currents characteristic of a FET input amplifier while still providing a 34 MHz bandwidth and a 135 ns settling time (to within $0.01 \%$ of final value for a 10 volt step). The AD843 is a member of the Analog Devices' family of wide bandwidth operational amplifiers. These devices are fabricated using Analog Devices' junction isolated complementary bipolar (CB) process. This process permits a combination of dc precision and wideband ac performance previously unobtainable in a monolithic op amp.
The $250 \mathrm{~V} / \mu \mathrm{s}$ slew rate and 0.6 nA input bias current of the AD843 ensure excellent performance in high speed sample-andhold applications and in high speed integrators. This amplifier is also ideally suited for high bandwidth active filters and high frequency signal conditioning circuits.
Unlike many high frequency amplifiers, the AD843 requires no external compensation and it remains stable over its full operating temperature range. It is available in five performance grades: the AD843J and AD843K are rated over the commercial temperature range of $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$. The AD843A and AD843B are rated over the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. The AD843S is rated over the military temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ and is available processed to MIL-STD-883B, Rev. C.

## CONNECTION DIAGRAMS



NC = NO CONNECT
TO-8 (H-12A) Package


Plastic (N-8) and Cerdip (Q-8) Package


NC = NO CONNECT

LCC (E-20A) Package


The AD843 is offered in either 8-pin plastic DIP or hermetic cerdip packages, in 16-pin SOIC, $20-\mathrm{Pin}$ LCC, or in a 12 -pin metal can. Chips are also available.

## PRODUCT HIGHLIGHTS

1. The high slew rate, fast settling time and low input bias current of the AD843 make it the ideal amplifier for 12-bit D/A and A/D buffers, for high speed sample-and-hold amplifiers and for high speed integrator circuits. The AD843 can replace many FET input hybrid amplifiers such as the LH0032, LH4104 and OPA600.
2. Fully differential inputs provide outstanding performance in all standard high frequency op amp applications such as signal conditioning and active filters.
3. Laser wafer trimming reduces the input offset voltage to 1 mV max (AD843K and AD843B).
4. Although external offset nulling is unnecessary in many applications, offset null pins are provided.
5. The AD843 does not require external compensation at closed loop gains of 1 or greater.

[^150]

## AD843

NOTES
${ }^{1}$ Standard Military Drawings Available: 5962-9098001M2A (SE/883B), 5962-9098001MXA (SH/883B), 5962-9098001MPA (SQ/883B).
${ }^{2}$ Specifications are guaranteed after 5 minutes at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.
${ }^{3}$ Full power bandwidth $=$ Slew Rate $/ 2 \pi V$ peak.
${ }^{4}$ All " S " grade $\mathrm{T}_{\min }-\mathrm{T}_{\max }$ specifications are tested with automatic test equipment at $\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ and $\mathrm{T}_{\mathrm{A}}=+125^{\circ} \mathrm{C}$.
${ }^{5}$ For outline information see Package Information section.
Specifications subject to change without notice.
Specifications in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed although only those shown in boldface are tested on all production units.

| ABSOLUTE MAXIMUM RATINGS ${ }^{1}$ |  |
| :---: | :---: |
| Supply Voltage | 18 V |
| Internal Power Dissipation ${ }^{2}$ |  |
| Plastic Package | 1.50 Watts |
| Cerdip Package | 1.35 Watts |
| 12-Pin Header Package | 1.80 Watts |
| 16-Pin SOIC Package | 1.50 Watts |
| 20-Pin LCC Package | 1.00 Watt |
| Input Voltage |  |
| Output Short Circuit Duration | Indefinite |
| Differential Input Voltage | $+\mathrm{V}_{\mathrm{s}}$ and $-\mathrm{V}_{\text {s }}$ |
| Storage Temperature Range (N, R) | $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Storage Temperature Range (Q, H, E) | $65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Operating Temperature Range |  |
| AD843J/K | 0 to $+70^{\circ} \mathrm{C}$ |
| AD843A/B | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| AD843S | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Lead Temperature Range (Soldering 60 sec) | $+300^{\circ} \mathrm{C}$ |
| ESD Rating | 500 V |

## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2} 8$-Pin Plastic Package: $\theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} /$ Watt
8-Pin Cerdip Package: $\theta_{\mathrm{JA}}=110^{\circ} \mathrm{C} / \mathrm{W}$ att
12-Pin Header Package: $\theta_{\mathrm{JA}}=80^{\circ} \mathrm{C} / \mathrm{W}$ att
16-Pin SOIC Package: $\theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} /$ Watt $20-$ Pin LCC Package: $\theta_{\mathrm{JA}}=150^{\circ} \mathrm{C} / \mathrm{W}$ att

## METALIZATION PHOTOGRAPH

Contact factory for latest dimensions.
Dimensions shown in inches and (mm).


FEATURES
Wide Bandwidth: 60 MHz at Gain of $\mathbf{- 1}$
33 MHz at Gain of $\mathbf{- 1 0}$
Very High Output Slew Rate: Up to 2000V/ $\boldsymbol{\mu s}$
20MHz Full Power Bandwidth, 20V pk-pk, $\mathrm{R}_{\mathrm{L}}=500 \Omega$
Fast Settling: 100ns to 0.1\% (10V Step)
Differential Gain Error: $0.03 \%$ at 4.4 MHz
Differential Phase Error: $0.15^{\circ}$ at 4.4 MHz
High Output Drive: $\pm 50 \mathrm{~mA}$ into $50 \Omega$ Load
Low Offset Voltage: 150 $\mu \mathrm{V}$ max (B Grade)
Low Quiescent Current: 6.5mA
Available in Tape and Reel in Accordance with EIA-481A Standard

## APPLICATIONS

## Flash ADC Input Amplifiers

High Speed Current DAC Interfaces
Video Buffers and Cable Drivers
Pulse Amplifiers

## PRODUCT DESCRIPTION

The AD844 is a high speed monolithic operational amplifier fabricated using Analog Devices' junction isolated complementary bipolar (CB) process. It combines high bandwidth and very fast large signal response with excellent dc performance. Although optimized for use in current to voltage applications and as an inverting mode amplifier, it is also suitable for use in many noninverting applications.
The AD844 can be used in place of traditional op amps, but its current feedback architecture results in much better ac performance, high linearity and an exceptionally clean pulse response.
This type of op amp provides a closed-loop bandwidth which is determined primarily by the feedback resistor and is almost independent of the closed-loop gain. The AD844 is free from the slew rate limitations inherent in traditional op amps and other current-feedback op amps. Peak output rate of change can be over $2000 \mathrm{~V} / \mu \mathrm{s}$ for a full 20 V output step. Settling time is typically 100 ns to $0.1 \%$, and essentially independent of gain. The AD844 can drive $50 \Omega$ loads to $\pm 2.5 \mathrm{~V}$ with low distortion and is short circuit protected to 80 mA .

The AD844 is available in four performance grades and three package options. In the 16 -pin SOIC ( R ) package, the AD844J is specified for the commercial temperature range of 0 to $+70^{\circ} \mathrm{C}$. The AD844A and AD844B are specified for the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ and are available in the cerdip (Q) package. The AD844A is also available in an 8-pin plastic mini-DIP (N). The AD844S is specified over the military temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. It is available in the 8 -pin cerdip ( Q ) package. " A " and " S " grade chips and devices processed to MIL-STD-883B, REV. C are also available.

## CONNECTION DIAGRAMS



16-Pin SOIC
(R) Package


## PRODUCT HIGHLIGHTS

1. The AD844 is a versatile, low cost component providing an excellent combination of ac and dc performance. It may be used as an alternative to the EL2020 and CLC400/1.
2. It is essentially free from slew rate limitations. Rise and fall times are essentially independent of output level.
3. The AD844 can be operated from $\pm 4.5 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ power supplies and is capable of driving loads down to $50 \Omega$, as well as driving very large capacitive loads using an external network.
4. The offset voltage and input bias currents of the AD844 are laser trimmed to minimize dc errors; $\mathrm{V}_{\mathrm{OS}}$ drift is typically $1 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ and bias current drift is typically $9 \mathrm{nA} /{ }^{\circ} \mathrm{C}$.
5. The AD844 exhibits excellent differential gain and differential phase characteristics, making it suitable for a variety of video applications with bandwidths up to 60 MHz .
6. The AD844 combines low distortion, low noise and low drift with wide bandwidth, making it outstanding as an input amplifier for flash A/D converters.
[^151]AD844—SPECIFICATIONS
(@ $\mathrm{T}_{\mathrm{A}}+25^{\circ} \mathrm{C}$ and $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V} \mathrm{dc}$, unless otherwise noted)


AD844

| Model | Conditions | AD844J/A |  |  | AD844B |  |  | AD844S |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| OUTPUT SLEW RATE | Overdriven Input | 1200 | 2000 |  | 1200 | 2000 |  | 1200 | 2000 |  | V/us |
| $\begin{aligned} & \text { FULL POWER BANDWIDTH } \\ & \mathrm{V}_{\text {OUT }}=20 \mathrm{~V} \mathrm{p-p}^{5} \\ & \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V} \mathrm{p}-\mathrm{p}^{5} \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{s}}= \pm 15 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 5 \mathrm{~V} \\ & \mathrm{THD}=3 \% \end{aligned}$ |  | $\begin{aligned} & 20 \\ & 20 \end{aligned}$ |  |  | $\begin{aligned} & 20 \\ & 20 \end{aligned}$ |  |  | $\begin{aligned} & 20 \\ & 20 \end{aligned}$ |  | $\begin{aligned} & \mathrm{MHz} \\ & \mathrm{MHz} \end{aligned}$ |
| ```OUTPUT CHARACTERISTICS Voltage Short Circuit Current \(\mathrm{T}_{\text {min }}-\mathrm{T}_{\text {max }}\) Output Resistance``` | $\mathrm{R}_{\text {LOAD }}=500 \Omega$ <br> Open Loop |  | $\begin{aligned} & 11 \\ & 80 \\ & 60 \\ & 15 \end{aligned}$ |  |  | $\begin{aligned} & 11 \\ & 80 \\ & 60 \\ & 15 \end{aligned}$ |  |  | $\begin{aligned} & 11 \\ & 80 \\ & 60 \\ & 15 \end{aligned}$ |  | $\begin{aligned} & \pm \mathrm{V} \\ & \mathrm{~mA} \\ & \mathrm{~mA} \\ & \Omega \end{aligned}$ |
| POWER SUPPLY Operating Range Quiescent Current $\mathrm{T}_{\text {min }}-\mathrm{T}_{\text {max }}$ |  | $\pm 4.5$ | $\begin{aligned} & 6.5 \\ & 7.5 \end{aligned}$ | $\begin{aligned} & \pm 18 \\ & 7.5 \\ & 8.5 \\ & \hline \end{aligned}$ | $\pm 4.5$ | $\begin{aligned} & 6.5 \\ & 7.5 \end{aligned}$ | $\begin{aligned} & \pm 18 \\ & 7.5 \\ & 8.5 \\ & \hline \end{aligned}$ | $\pm 4.5$ | $\begin{aligned} & 6.5 \\ & 8.5 \end{aligned}$ | $\begin{aligned} & \pm 18 \\ & 7.5 \\ & 9.5 \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~mA} \\ & \mathrm{~mA} \end{aligned}$ |

## NOTES

${ }^{1}$ Rated performance after a 5 minute warmup at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
${ }^{2}$ Input signal 285 mV p-p carrier ( 40 IRE) riding on 0 to 642 mV ( 90 IRE) ramp. $\mathrm{R}_{\mathrm{L}}=100 \Omega$; R1, R2 $=300 \Omega$.
${ }^{3}$ Input signal $0 \mathrm{dBm}, \mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=500 \Omega, \mathrm{R} 1=500 \Omega, \mathrm{R} 2=500 \Omega$ in Figure 26.
${ }^{4}$ Input signal $0 \mathrm{dBm}, \mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=500 \Omega, \mathrm{R1}=500 \Omega, \mathrm{R} 2=50 \Omega$ in Figure 26.
${ }^{5} \mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=500 \Omega, \mathrm{R} 1=1 \mathrm{k} \Omega, \mathrm{R} 2=1 \mathrm{k} \Omega$ in Figure 26.
${ }^{6} \mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=500 \Omega, \mathrm{R} 1=500 \Omega, \mathrm{R} 2=50 \Omega$ in Figure 26.
Specifications subject to change without notice. All min and max specifications are guaranteed.
Specifications shown in boldface are tested on all production units at final electrical test.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$



ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Option |
| :--- | :--- | :--- |
| AD844JR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{R}-16$ |
| AD844JR-REEL | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Tape and Reel |
| AD844AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| AD844AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |
| AD844BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |
| AD844SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |
| AD844SQ/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |
| 5962-8964401PA | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |
| AD844A Chips | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Die |
| AD844S Chips | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Die |

[^152]
## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2} 8$-Pin Plastic Package: $\theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} /$ Watt 8-Pin Cerdip Package: $\theta_{\mathrm{JA}}=110^{\circ} \mathrm{C} /$ Watt 16-Pin SOIC Package: $\theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} /$ Watt $^{2}$

## METALIZATION PHOTOGRAPH

Contact factory for latest dimensions. Dimensions shown in inches and (mm).


SUBTRATE CONNECTED
TO $+V_{s}$

ANALOG

## FEATURES

## Replaces Hybrid Amplifiers in Many Applications

## AC PERFORMANCE:

Settles to $\mathbf{0 . 0 1 \%}$ in 350 ns
100 V/ $\mu \mathrm{s}$ Slew Rate
12.8 MHz min Unity-Gain Bandwidth 1.75 MHz Full-Power Bandwidth at 20 V p-p

DC PERFORMANCE:
0.25 mV max Input Offset Voltage
$5 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ max Offset Voltage Drift
0.5 nA Input Bias Current
$250 \mathrm{~V} / \mathrm{mV}$ min Open-Loop Gain
$4 \mu \mathrm{\mu}$ p-p max Voltage Noise, 0.1 Hz to 10 Hz 94 dB min CMRR
Available in Plastic Mini-DIP, Hermetic Cerdip and SOIC Packages. Also Available in Tape and Reel in Accordance with EIA-481A Standard

## PRODUCT DESCRIPTION

The AD845 is a fast, precise, N channel JFET input, monolithic operational amplifier. It is fabricated using Analog Devices' complementary bipolar (CB) process. Advanced laserwafer trimming technology enables the very low input offset voltage and offset voltage drift performance to be realized. This precision, when coupled with a slew rate of $100 \mathrm{~V} / \mu \mathrm{s}$, a stable unity-gain bandwidth of 16 MHz , and a settling time of 350 ns $0.01 \%$-while driving a parallel load of 100 pF and $500 \Omega$ represents a combination of features unmatched by any FET input IC amplifier. The AD845 can easily be used to upgrade many existing designs which use BiFET or FET input hybrid amplifiers and, in some cases, those which use bipolar input op amps.
The AD845 is ideal for use in applications such as active filters, high speed integrators, photo diode preamps, sample-and-hold amplifiers, $\log$ amplifiers, and in buffering $A / D$ and $D / A$ converters. The $250 \mu \mathrm{~V}$ max input offset voltage makes offset nulling unnecessary in many applications. The common-mode rejection ratio of 110 dB over a $\pm 10 \mathrm{~V}$ input voltage range represents exceptional performance for a JFET input high speed op amp. This, together with a minimum open-loop gain of $250 \mathrm{~V} / \mathrm{mV}$ ensures that 12 -bit performance is achieved, even in unity-gain buffer circuits.

## CONNECTION DIAGRAMS



The AD845 conforms to the standard op amp pinout except that offset nulling is to $\mathrm{V}+$. The AD845J and AD845K grade devices are available specified to operate over the commercial 0 to $+70^{\circ} \mathrm{C}$ temperature range. AD845A and AD845B devices are specified for operation over the $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ industrial temperature range. The AD845S is specified to operate over the full military temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. Both the industrial and military versions are available in 8 -pin cerdip packages. The commercial version is available in an 8 -pin plastic mini-DIP and 16-pin SOIC; " J " and " S " grade chips are also available.

## PRODUCT HIGHLIGHTS

1. The high slew rate, fast settling time, and dc precision of the AD845 make it ideal for high speed applications requiring 12-bit accuracy.
2. The performance of circuits using the LF400, HA2520/2/5, HA2620/2/5, 3550, OPA605, and LH0062 can be upgraded in most cases.
3. The AD845 is unity-gain stable and internally compensated.
4. The AD845 is specified while driving $100 \mathrm{pF} / 500 \Omega$ loads.

[^153] complete data sheet, call our fax retrieval system at 1-800-446-6212.
(@ $+25^{\circ} \mathrm{C}$ and $\pm 15 \mathrm{~V} \mathrm{dc}$, unless otherwise noted)

| Model | Conditions | Min | $\begin{aligned} & \text { AD845J/A } \\ & \text { Typ } \end{aligned}$ | Max | Min | AD845K/B <br> Typ | Max | Min | $\begin{aligned} & \text { AD845S } \\ & \text { Typ } \end{aligned}$ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT OFFSET VOLTAGE ${ }^{1}$ Initial Offset Offset Drift | $\mathrm{T}_{\text {min }}-\mathrm{T}_{\text {max }}$ |  | $0.7$ | $\begin{aligned} & 1.5 \\ & 2.5 \\ & 20 \end{aligned}$ |  | $\begin{aligned} & 0.1 \\ & 1.5 \end{aligned}$ | $\begin{aligned} & 0.25 \\ & 0.4 \\ & 5.0 \end{aligned}$ |  | 0.25 | $\begin{aligned} & 1.0 \\ & 2.0 \\ & 10 \end{aligned}$ | mV <br> mV <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| INPUT BIAS CURRENT ${ }^{2}$ Initial | $\begin{aligned} & \mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V} \\ & \mathrm{~T}_{\min }-\mathrm{T}_{\max } \end{aligned}$ |  | 0.75 | $\begin{aligned} & 2 \\ & 45 / 75 \end{aligned}$ |  | 0.5 | $\begin{aligned} & 1 \\ & 18 / 38 \end{aligned}$ |  | 0.75 | $\begin{aligned} & \mathbf{2} \\ & \mathbf{5 0 0} \end{aligned}$ | $\begin{aligned} & \mathrm{nA} \\ & \mathrm{nA} \end{aligned}$ |
| INPUT OFFSET CURRENT Initial | $\begin{aligned} & \mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V} \\ & \mathrm{~T}_{\min }-\mathrm{T}_{\max } \end{aligned}$ |  | 25 | $\begin{aligned} & 300 \\ & 3 / 6.5 \end{aligned}$ |  | 15 | $\begin{aligned} & 100 \\ & 1.2 / 2.6 \end{aligned}$ |  | 25 | $\begin{aligned} & 300 \\ & 20 \end{aligned}$ | $\begin{aligned} & \mathrm{pA} \\ & \mathrm{nA} \end{aligned}$ |
| INPUT CHARACTERISTICS <br> Input Resistance Input Capacitance |  |  | $\begin{aligned} & 10^{11} \\ & 4.0 \end{aligned}$ |  |  | $\begin{aligned} & 10^{11} \\ & 4.0 \end{aligned}$ |  |  | $\begin{aligned} & 10^{11} \\ & 4.0 \end{aligned}$ |  | $\begin{aligned} & \mathrm{k} \Omega \\ & \mathrm{pF} \end{aligned}$ |
| INPUT VOLTAGE RANGE <br> Differential <br> Common Mode <br> Common-Mode Rejection | $\mathrm{V}_{\mathrm{CM}}= \pm 10 \mathrm{~V}$ | $\begin{aligned} & \pm 10 \\ & 86 \end{aligned}$ | $\begin{aligned} & \pm 20 \\ & +10.5 /-13 \\ & 110 \end{aligned}$ |  | $\begin{aligned} & \pm 10 \\ & 94 \end{aligned}$ | $\begin{aligned} & \pm 20 \\ & +10.5 /-13 \\ & 113 \end{aligned}$ |  | $\begin{aligned} & \pm 10 \\ & 86 \end{aligned}$ | $\begin{aligned} & \pm 20 \\ & +10.5 /-13 \\ & 110 \end{aligned}$ |  | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~dB} \end{aligned}$ |
| INPUT VOLTAGE NOISE | $\begin{aligned} & 0.1 \text { to } 10 \mathrm{~Hz} \\ & \mathrm{f}=10 \mathrm{~Hz} \\ & \mathrm{f}=100 \mathrm{~Hz} \\ & \mathrm{f}=1 \mathrm{kHz} \\ & \mathrm{f}=10 \mathrm{kHz} \\ & \mathrm{f}=100 \mathrm{kHz} \end{aligned}$ |  | $\begin{aligned} & 4 \\ & 80 \\ & 60 \\ & 25 \\ & 18 \\ & 12 \end{aligned}$ |  |  | $\begin{aligned} & 4 \\ & 80 \\ & 60 \\ & 25 \\ & 18 \\ & 12 \end{aligned}$ |  |  | $\begin{aligned} & 4 \\ & 80 \\ & 60 \\ & 25 \\ & 18 \\ & 12 \end{aligned}$ |  | $\begin{aligned} & \mu \mathrm{V} \text { p- } \\ & \mathrm{nV} / \sqrt{\mathrm{Hz}} \\ & \mathrm{nV} / \sqrt{\mathrm{Hz}} \\ & \mathrm{nV} / \sqrt{\mathrm{Hz}} \\ & \mathrm{nV} / \sqrt{\mathrm{Hz}} \\ & \mathrm{nV} / \sqrt{\mathrm{Hz}} \end{aligned}$ |
| INPUT CURRENT NOISE | $\mathrm{f}=1 \mathrm{kHz}$ |  | 0.1 |  |  | 0.1 |  |  | 0.1 |  | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
| OPEN-LOOP GAIN | $\begin{aligned} & \mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{LOAD}} \geq 2 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{LOAD}} \geq 500 \Omega \\ & \mathrm{~T}_{\min }-\mathrm{T}_{\max } \end{aligned}$ | $\begin{aligned} & 200 \\ & 100 \\ & 70 \end{aligned}$ | $\begin{aligned} & 500 \\ & 250 \end{aligned}$ |  | $\begin{aligned} & 250 \\ & 125 \\ & 75 \end{aligned}$ | $\begin{aligned} & 500 \\ & 250 \end{aligned}$ |  | $\begin{aligned} & 200 \\ & 100 \\ & 50 \\ & \hline \end{aligned}$ | $\begin{aligned} & 500 \\ & 250 \end{aligned}$ |  | $\begin{aligned} & \mathrm{V} / \mathrm{mV} \\ & \mathrm{~V} / \mathrm{mV} \\ & \mathrm{~V} / \mathrm{mV} \end{aligned}$ |
| ```OUTPUT CHARACTERISTICS``` | $\mathrm{R}_{\text {LOAD }} \geq 500 \Omega$ Short Circuit Open Loop | $\pm 12.5$ | $\begin{aligned} & 50 \\ & 5 \end{aligned}$ |  | $\pm 12.5$ | $\begin{aligned} & 50 \\ & 5 \end{aligned}$ |  | $\pm 12.5$ | $\begin{aligned} & 50 \\ & 5 \end{aligned}$ |  | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~mA} \\ & \Omega \end{aligned}$ |
| FREQUENCY RESPONSE <br> Small Signal <br> Full Power Bandwidth ${ }^{3}$ <br> Rise Time <br> Overshoot <br> Slew Rate <br> Settling Time | Unity Gain $\begin{aligned} & \mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \\ & \mathrm{R}_{\text {LOAD }}=500 \Omega \end{aligned}$ <br> 10 V Step $\begin{aligned} & \mathrm{C}_{\text {LOAD }}=100 \mathrm{pF} \\ & \mathrm{R}_{\text {LOAD }}=500 \Omega \\ & \text { to } 0.01 \% \\ & \text { to } 0.1 \% \end{aligned}$ | 12.8 <br> 80 | 16 <br> 1.75 <br> 20 <br> 20 <br> 100 <br> 350 <br> 250 | ' | 13.6 <br> 94 | 16 <br> 1.75 <br> 20 <br> 20 <br> 100 <br> 350 <br> 250 | $500$ | 13.6 <br> 94 | 16 <br> 1.75 <br> 20 <br> 20 <br> 100 <br> 350 <br> 250 | 500 | MHz <br> MHz <br> ns <br> \% <br> $\mathrm{V} / \mu \mathrm{s}$ <br> ns <br> ns <br> ns <br> ns |
| DIFFERENTIAL GAIN | $\mathrm{f}=4.4 \mathrm{MHz}$ |  | 0.04 |  |  | 0.04 |  |  | 0.04 |  | \% |
| DIFFERENTIAL PHASE | $\mathrm{f}=4.4 \mathrm{MHz}$ |  | 0.02 |  |  | 0.02 |  |  | 0.02 |  | Degree |
| POWER SUPPLY <br> Rated Performance <br> Operating Range <br> Rejection Ratio <br> Quiescent Current | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}= \pm 5 \text { to } \pm 15 \mathrm{~V} \\ & \mathrm{~T}_{\min } \text { to } \mathrm{T}_{\max } \end{aligned}$ | $\begin{aligned} & \pm 4.75 \\ & 88 \end{aligned}$ | $\begin{aligned} & \pm 15 \\ & 110 \\ & 10 \end{aligned}$ | $\begin{aligned} & \pm 18 \\ & 12 \end{aligned}$ | $\begin{aligned} & \pm 4.75 \\ & 95 \end{aligned}$ | $\begin{aligned} & \pm 15 \\ & 113 \\ & 10 \end{aligned}$ | $\begin{aligned} & \pm 18 \\ & 12 \end{aligned}$ | $\begin{aligned} & \pm 4.75 \\ & 88 \end{aligned}$ | $\begin{aligned} & \pm 15 \\ & 110 \\ & 10 \end{aligned}$ | $\pm 18$ 12 | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~dB} \\ & \mathrm{~mA} \end{aligned}$ |

## NOTES

${ }^{1}$ Input offset voltage specifications are guaranteed after 5 minutes of operation at $T_{A}=+25^{\circ} \mathrm{C}$.
${ }^{2}$ Bias current specifications are guaranteed maximum at either input after 5 minutes of operation at $T_{A}=+25^{\circ} \mathrm{C}$.
${ }^{3}$ FPBW $=$ slew rate $/ 2 \pi$ V peak.
${ }^{4}$ " S " grade $\mathrm{T}_{\min }-\mathrm{T}_{\max }$ are tested with automatic test equipment at $\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ and $\mathrm{T}_{\mathrm{A}}=+125^{\circ} \mathrm{C}$.
All min and max specifications are guaranteed. Specifications shown in boldface are tested on all production units at final electrical test. Results from these tests are used to calculate outgoing quality levels.
Specifications subject to change without notice.

## AD845

| ABSOLUTE MAXIMUM RATINGS ${ }^{1}$ |  |
| :---: | :---: |
| Supply Voltage | 18 V |
| Internal Power Dissipation ${ }^{2}$ |  |
| Plastic Mini-DIP | 1.6 Watts |
| Cerdip | 1.4 Watts |
| 16-Pin SOIC | 1.5 Watts |
| Input Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm \mathrm{V}_{\text {S }}$ |  |
| Output Short-Circuit Duration . . . . . . . . . . . . . . Indefinite |  |
| Differential Input Voltage . . . . . . . . . . . $+\mathrm{V}_{\mathrm{S}}$ and $-\mathrm{V}_{\text {S }}$ |  |
| Storage Temperature Range |  |
| Q | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| N, R | $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Lead Temperature Range (Soldering 60 s | . . . . $+300^{\circ} \mathrm{C}$ |

## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ Mini-DIP package: $\theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} / \mathrm{W}$; cerdip package: $\theta_{\mathrm{JA}}=110^{\circ} \mathrm{C} / \mathrm{W}$; SOIC package: $\theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} / \mathrm{W}$.

## METALIZATION PHOTOGRAPH

Dimensions shown in inches and (mm).
Contact factory for latest dimensions.


SUBSTRATE CONNECTED TO $+\mathbf{v}_{\mathbf{s}}$

ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD845JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic Mini-DIP | $\mathrm{N}-8$ |
| AD845KN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 8-Pin Plastic Mini-DIP | $\mathrm{N}-8$ |
| AD845JR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 16-Pin SOIC | $\mathrm{R}-16$ |
| AD845AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Cerdip | $\mathrm{Q}-8$ |
| AD845BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Cerdip | $\mathrm{Q}-8$ |
| AD845SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Cerdip | $\mathrm{Q}-8$ |
| AD845SQ/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Cerdip | $\mathrm{Q}-8$ |
| 5962-8964501PA | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Cerdip | $\mathrm{Q}-8$ |
| AD845J Chips | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Die |  |
| AD845S Chips | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Die |  |
| AD845JR-Reel | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Tape \& Reel |  |

${ }^{\star} \mathrm{N}=$ Plastic DIP; $\mathrm{Q}=$ Cerdip; $\mathrm{R}=$ Small Outline IC (SOIC). For outline information see Package Information section.

## FEATURES

## AC PERFORMANCE

Small Signal Bandwidth: $80 \mathrm{MHz}\left(\mathrm{A}_{\mathbf{v}}=\mathbf{- 1}\right)$
Slew Rate: $450 \mathrm{~V} / \mu \mathrm{s}$
Full Power Bandwidth: 6.8 MHz at 20 V p-p, $R_{L}=500 \Omega$
Fast Settling: for 10 V Step: 110 ns to $\mathbf{0 . 0 1 \%}$, 80 ns to 0.1\%
Differential Gain: <0.01\% @ 4.4 MHz
Differential Phase: $<0.028^{\circ}$ @ 4.4 MHz
Total Harmonic Distortion (THD): 0.0005\% @ 100 kHz
Open-Loop Transimpedance: $200 \mathrm{M} \Omega$
Input Voltage Noise: $2 \mathrm{nV} / \sqrt{\mathrm{Hz}}$

## DC PERFORMANCE

Input Offset Voltage: $75 \mu \mathrm{~V}$ max (B Grade)
Input Offset Drift: $3.5 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C} \max (\mathrm{B}$ Grade)
Quiescent Supply Current: 6.5 mA max

## APPLICATIONS

High Speed DAC Buffers
Multiflash ADC Error Amplifiers
Flash ADC Buffers
Coaxial Cable Drivers
High Performance Audio Circuitry
Available in Plastic Mini-DIP, Hermetic Cerdip, and
Hermetic Metal Can Packages
MIL-STD-883B Parts Available

## PRODUCT DESCRIPTION

The AD846 is a monolithic, very high speed operational amplifier offering high performance. Although technically classed as a current-feedback or transimpedance amplifier, it may be used in much the same way as traditional op amps while providing significant performance benefits. Employing Analog Devices' junction isolated complementary bipolar (CB) process, the AD846 achieves true " 12 -bit" ( $0.01 \%$ ) precision on critical ac and dc parameters, a level of performance unmatched by amplifiers fabricated using either the dielectrically isolated (DI) or other bipolar processes.

The AD846 offers significant advantages over conventional high speed operational amplifiers. It maintains a nearly constant bandwidth and settling time to $0.01 \%$ over a wide range of closed-loop gains. This makes the AD846 ideal for amplifying the residue in multiple-pass analog-to-digital converters.

## CONNECTION DIAGRAM



Other advantages include: low input errors and high open-loop transresistance ( $200 \mathrm{M} \Omega$ ) into a $500 \Omega$ load, ensuring true 12 -bit dc accuracy for closed-loop gains from -1 to gains greater than -100 . This combination of ac and dc performance makes the AD846 an excellent choice for buffering precision high speed DACs and flash ADCs.

The AD846 is available in three performance grades. The AD846A and AD846B are rated over the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. The AD846S is rated over the full military temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ and is available processed to MIL-STD-883B, Rev C.
Extended reliability PLUS screening is available specified over the commercial temperature range. PLUS screening includes 168 hour burn-in as well as other environmental and physical tests. The AD846 is available in two types of 8-pin package: plastic mini-DIP and hermetic cerdip. " $A$ " and " $S$ " grade chips are also available.

## PRODUCT HIGHLIGHTS

1. The AD846 achieves settling times of 110 ns to $0.01 \%$ for gains of -1 to -10 , with a $450 \mathrm{~V} / \mu \mathrm{s}$ slew rate, while consuming only 5 mA of supply current.
2. For closed-loop gains of -1 to -100 , the high speed performance of the AD846 is achieved without sacrificing full 12 -bit dc precision.
3. The AD846 is well suited to line driver and video buffer applications where the properties of low distortion and high slew rate are required.

This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

|  |  |  | AD846A |  |  | AD846B |  |  | AD846S |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Model | Conditions | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | Units |
| INPUT OFFSET VOLTAGE ${ }^{1}$ |  |  |  |  |  |  |  |  |  |  |  |
| Initial |  |  | 25 | 200 |  | 25 | 75 |  | 25 | 200 | $\mu \mathrm{V}$ |
| $\mathrm{T}_{\text {min }}-\mathrm{T}_{\text {max }}$ |  |  | 50 | 350 |  | 50 | 125 |  | 100 | 350 | $\mu \mathrm{V}$ |
| : vs. Temperature |  |  | 0.8 | 5 |  | 0.8 | 3.5 |  | 1 | 5.5 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| vs. Supply (PSRR) | $5 \mathrm{~V}-18 \mathrm{~V}^{2}$ |  |  |  |  |  |  |  |  |  |  |
| Initial |  | 110 | 125 |  | 120 | 125 |  | 110 | 125 |  | dB |
| $\mathrm{T}_{\text {min }}-\mathrm{T}_{\text {max }}$ |  | 110 | 120 |  | 116 | 120 |  | 94 | 116 |  | dB |
| vs. Common Mode (CMRR) | $\mathrm{V}_{\mathrm{CM}}= \pm 10 \mathrm{~V}$ |  |  |  |  |  |  |  |  |  |  |
| Initial |  | 110 | 125 |  | 120 | 125 |  | 110 | 125 |  |  |
| $\mathrm{T}_{\text {min }}-\mathrm{T}_{\text {max }}$ |  | 110 | 120 |  | $116$ | 120 |  | $94$ | $116$ |  |  |
| INPUT BIAS CURRENT ${ }^{3}$ |  |  |  |  |  |  |  |  |  |  |  |
| -Input Bias Current |  |  |  |  |  |  |  |  |  |  |  |
| Initial |  |  | 150 | 450 |  | 100 | 250 |  | 150 | 450 |  |
| $\mathrm{T}_{\text {min }}-\mathrm{T}_{\text {max }}$ |  |  | 450 | 1200 |  | 400 | 750 |  | 1000 | 1500 | $\mathrm{nA}$ |
| vs. Temperature |  |  | 6 | 20 |  | 6 | 17 |  | 9 | 20 | $n A /{ }^{\circ} \mathrm{C}$ |
| vs. Supply | $5 \mathrm{~V}-18 \mathrm{~V}^{2}$ |  |  |  |  |  |  |  |  |  |  |
| Initial |  |  | 9 | 15 |  | 9 | 10 |  |  | 15 | nA/V |
| $\mathrm{T}_{\text {min }}-\mathrm{T}_{\text {max }}$ |  |  | 11 | 20 |  | 11 | 15 |  | 11 | 25 | nA/V |
| vs. Common Mode | $\mathrm{V}_{\mathrm{CM}}= \pm 10 \mathrm{~V}$ |  |  |  |  |  |  |  |  |  |  |
| Initial |  |  | 5 | 10 |  | 3 | 5 |  | 5 | 10 | $n A / V$ |
| $\mathrm{T}_{\text {min }}-\mathrm{T}_{\text {max }}$ |  |  | 5 | 15 |  | 3 | 7 |  | 5 | 20 | $n A / V$ |
| +Input Bias Current |  |  |  |  |  |  |  |  |  |  |  |
| Initial | $\therefore \quad$ a |  | 3 | 15 |  | 3 | 5 |  | 3 | 15 | $\mu \mathrm{A}$ |
| $\mathrm{T}_{\min }-\mathrm{T}_{\text {max }}$ |  |  | 4 | 20 |  | 4 | 7 |  | 5 | 20 | $\mu \mathrm{A}$ |
| vs. Temperature |  |  | 15 | 80 |  | 15 | 45 |  | 15 | 80 | nA/ ${ }^{\circ} \mathrm{C}$ |
| vs. Supply | $5 \mathrm{~V}-18 \mathrm{~V}^{2}$ |  |  |  |  |  |  |  |  |  |  |
| Initial |  |  | 5 | 15 |  | 5 | 10 |  | 5 | 15 | nA/V |
| $\mathrm{T}_{\text {min }}-\mathrm{T}_{\text {max }}$ |  |  | 5 | 20 |  | 5 | 15 |  | 5 | 20 | $n A / V$ |
| vs. Common Mode | $\mathrm{V}_{\mathrm{CM}}= \pm 10 \mathrm{~V}$ |  |  |  |  |  |  |  |  |  |  |
| Initial |  |  | 5 | 15 |  | 3 | 10 |  | 5 | 15 | $n A / V$ |
| $\mathrm{T}_{\text {min }}-\mathrm{T}_{\text {max }}$ |  |  | 5 | 15 |  | 3 | 10 |  | 5 | 20 | $n A / V$ |
| INPUT CHARACTERISTICS |  |  |  |  |  |  |  |  |  |  |  |
| Input Resistance |  |  |  |  |  |  |  |  |  |  |  |
| - Input |  | 50 |  |  | 50 |  |  | 5010 |  |  | $\Omega$ |
| +Input |  |  | 10 |  |  | 10 |  |  |  |  | k $\Omega$ |
| Input Capacitance |  |  |  |  |  |  |  |  |  |  |  |
| - Input |  | 2 |  |  | 2 |  |  | 2 |  |  | $\mathrm{pF}$ |
| + Input |  | 2 |  |  | 2 |  |  | 2 |  |  |  |
| INPUT VOLTAGE RANGE Common Mode |  | $\pm 10$ |  |  | $\pm 10$. |  |  | $\pm 10$ |  |  | V |
| INPUT VOLTAGE NOISE | $\mathrm{F}=1 \mathrm{kHz}$ |  | 2 |  |  | 2 |  |  | 2 |  | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| Input Current Noise |  |  |  |  |  |  |  |  |  |  |  |
| - Input | 1 kHz |  | 20 |  |  | 20 |  |  | 20 |  | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
| + Input | 1 kHz |  | 6 |  |  | 6 |  |  | 6 |  | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
| OPEN LOOP |  |  |  |  |  |  |  |  |  |  |  |
| TRANSRESISTANCE | $\begin{aligned} & \mathrm{V}_{\text {OUT }}= \pm 10 \mathrm{~V} \\ & \mathrm{R}_{\text {LOAD }}=500 \Omega \end{aligned}$ |  | 200 |  |  | 200 |  |  | 200 |  |  |
|  | $\mathrm{T}_{\text {min }}^{\text {LOAD }}$ - $\mathrm{max}^{\text {max }}$ | 50 |  |  | 75 |  |  | 50 | 200 |  | $\mathrm{M} \Omega$ |
| OUTPUT CHARACTERISTICS |  |  |  |  |  |  |  |  |  |  |  |
| Voltage | $\mathbf{R}_{\text {LOAD }}=500 \Omega$ | $\pm 10$ | 65 |  | $\pm 10$ |  |  | $\pm 10$ |  |  | V |
| Current | Short Circuit |  |  |  | 65 |  |  | 65 |  |  | mA |
| Output Resistance | Open Loop |  | 16 |  | 16 |  |  | 16 |  |  | $\Omega$ |
|  |  |  |  |  |  |  |  |  |  |  |  |
| Small Signal Bandwidth | $A_{V}=-1 \mathbf{R}_{\mathbf{F}}=1 \mathrm{l}$ |  | 80 | $\cdots$ |  | 80 |  |  | 80 |  | MHz |
| ( -3 dB ) | $A_{V}=-10 \mathrm{R}_{\mathbf{F}}=875 \Omega$ |  | 31 |  |  | 31 |  |  | 31 |  | MHz |
| Full Power Bandwidth ${ }^{4}$ | $\mathrm{A}_{\mathbf{V}}=-30 \mathrm{R}_{\mathbf{F}}=875 \Omega$ | 15 |  |  | 15 |  |  |  | 15 |  | MHz |
|  | $\mathrm{V}_{\text {OUT }}=20 \mathrm{~V} \mathrm{p}-\mathrm{p}$ | 6.8 |  |  | 6.8 |  |  | 6.8 |  |  | MHz |
|  | $\mathrm{R}_{\mathrm{I}}=500 \Omega$ |  |  |  |  |  |  |  |  |  |  |  |  |
| Rise Time | $A_{V}=-1$ | 10 |  |  | 10 |  |  | 10 |  |  | ns |
| Overshoot | $A_{v}=-1$ | 20 |  |  | 20 |  |  | 20 |  |  | \% |
| Slew Rate | $A_{V}=-1$ | 450 |  |  | 450 |  |  | 450 |  |  | V/ $\mu \mathrm{s}$ |
|  |  |  |  |  |  |  |  |  |  |  |  |
| 10 V Step, $\mathrm{A}_{\mathrm{V}}=-1$ | to 0.1\% | 80 |  |  | 80 |  |  | 80 |  |  | ns |
|  | to 0.01\% | 110 |  |  | 110 |  |  | 110 |  |  | ns |
| $\begin{aligned} & \text { TOTAL HARMONIC } \\ & \text { DISTORTION }^{5} \end{aligned}$ | $\mathrm{F}=100 \mathrm{kHz}$ | 0.0005 |  |  | 0.0005 |  |  |  | 0.0005 |  | \% |


| Model | Conditions | AD846A |  |  | AD846B |  |  | AD846S |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| DIFFERENTIAL GAIN | $\mathrm{F}=4.4 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=100 \Omega$ |  | 0.01 |  |  | 0.01 |  |  | 0.01 |  | \% |
| DIFFERENTIAL PHASE | $\mathrm{F}=4.4 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=100 \Omega$ |  | 0.028 |  |  | 0.028 |  |  | 0.028 |  | Degree |
| POWER SUPPLY Rated Performance Operating Range Quiescent Current | $\mathrm{T}_{\text {min }}-\mathrm{T}_{\text {max }}$ | $\pm 5$ | $\begin{aligned} & \pm 15 \\ & 5 \end{aligned}$ | $\begin{aligned} & \pm 18 \\ & \mathbf{6 . 5} \end{aligned}$ | $\pm 5$ | $\begin{aligned} & \pm 15 \\ & 5 \end{aligned}$ | $\begin{aligned} & \pm 18 \\ & 6.5 \end{aligned}$ | $\pm 5$ | $\begin{aligned} & \pm 15 \\ & 5 \end{aligned}$ | $\underset{7}{ \pm 18}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~mA} \end{aligned}$ |
| TRANSISTOR COUNT |  |  | 72 |  |  | 72 |  |  | 72 |  |  |

NOTES
${ }^{1}$ Input Offset Voltage Specifications are guaranteed after 5 minutes at $T_{A}=+25^{\circ} \mathrm{C}$.
${ }^{2}$ Test Conditions: $+\mathrm{V}_{\mathrm{s}}=15 \mathrm{~V},-\mathrm{V}_{\mathrm{s}}=5 \mathrm{~V}$ to 18 V and $+\mathrm{V}_{\mathrm{s}}=5 \mathrm{~V}$ to $18 \mathrm{~V},-\mathrm{V}_{\mathrm{s}}=15 \mathrm{~V}$.
${ }^{3}$ Bias Current Specifications are guaranteed maximum after 5 minutes at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.
${ }^{4}$ FPBW $=$ Slew Rate/ $2 \pi V_{\text {Peak }}$.
${ }^{5}$ Total Harmonic Distortion.
All min and max specifications are guaranteed. Specifications shown in boldface are tested on all production units at final electrical test.
Results from those tests are used to calculate outgoing quality levels.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

| Supply Voltage |  |
| :---: | :---: |
| Internal Power Dissipation ${ }^{2}$ |  |
| Plastic Package | 1.5 W |
| Cerdip Package | 1.3 W |
| Common-Mode Input Voltage, Max Safe | $\left\|\mathrm{V}_{\mathrm{S}}\right\|-3 \mathrm{~V}$ |
| Output Short Circuit Duration | Indefinite |
| Continuous Input Current |  |
|  |  |
| Inverting or Noninverting | 2.0 mA |
| Storage Temperature Range (Q) | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Storage Temperature Range (N) | $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Operating Temperature Range |  |
| AD846A/B | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| AD846S | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |

Lead Temperature Range (Soldering 60 sec ) . . . . . . $+300^{\circ} \mathrm{C}$
ESD Rating . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 3500 V
NOTES
${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only; the functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ Maximum internal power dissipation is specified so that $\mathrm{T}_{\mathrm{J}}$ does not exceed $+175^{\circ} \mathrm{C}$ at an ambient temperature of $+25^{\circ} \mathrm{C}$, derate cerdip (Q) package at $8.7 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ and plastic (N) package at $10 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$.
Plastic Package: $\theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} / \mathrm{Watt}, \theta_{\mathrm{JC}}=33^{\circ} \mathrm{C} / \mathrm{W}$.
Cerdip Package: $\theta_{\mathrm{JA}}=110^{\circ} \mathrm{C} / \mathrm{Watt}, \theta_{\mathrm{JC}}=30^{\circ} \mathrm{C} / \mathrm{W}$.

## METALIZATION PHOTOGRAPH

Dimensions shown in inches and (mm). Consult factory for latest dimensions.

ORDERING GUIDE

| ORDERING GUIDE |  |  |
| :--- | :---: | :---: |
| Model ${ }^{\mathbf{1}}$ | Temperature Range | Package <br> Option |
| AD846AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| AD846BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| AD846AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |
| AD846BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |
| AD846SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |
| AD846SQ/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |
| 5962-8964601PA | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |
|  |  |  |
| NOTES |  |  |
| 1"4" and "S" grade chips are also available. |  |  |
| ${ }^{2} \mathrm{~N}=$ Plastic DIP Package; $\mathrm{Q}=$ Cerdip Package. For outline information see |  |  |
| Package Information section. |  |  |

## NOTES

1" A " and " S " grade chips are also available.
${ }^{2} \mathrm{~N}=$ Plastic DIP Package; $\mathrm{Q}=$ Cerdip Package. For outline information see Package Information section.


## FEATURES

Superior Performance
High Unity Gain BW: $50 \mathbf{~ M H z}$
Low Supply Current: 5.3 mA
High Slew Rate: 300 V/ $\mu \mathrm{s}$
Excellent Video Specifications 0.04\% Differential Gain (NTSC and PAL)
$0.19^{\circ}$ Differential Phase (NTSC and PAL)
Drives Any Capacitive Load
Fast Settling Time to $0.1 \%$ ( 10 V Step): 65 ns
Excellent DC Performance
High Open-Loop Gain $5.5 \mathrm{~V} / \mathrm{mV}\left(\mathrm{R}_{\text {LOAD }}=1 \mathrm{k} \Omega\right)$
Low Input Offset Voltage: 0.5 mV
Specified for $\pm 5$ V and $\pm 15$ V Operation
Available in a Wide Variety of Options
Plastic DIP and SOIC Packages
Cerdip Package
Die Form
MIL-STD-883B Processing
Tape \& Reel (EIA-481A Standard)
Dual Version Available: AD827 (8 Lead)
Enhanced Replacement for LM6361
Replacement for HA2544, HA2520/2/5 and EL2020

## APPLICATIONS

Video Instrumentation
Imaging Equipment
Copiers, Fax, Scanners, Cameras
High Speed Cable Driver
High Speed DAC and Flash ADC Buffers

## PRODUCT DESCRIPTION

The AD847 represents a breakthrough in high speed amplifiers offering superior ac \& dc performance and low power, all at low cost. The excellent dc performance is demonstrated by its $\pm 5 \mathrm{~V}$


Quiescent Current vs. Supply Voltage

## CONNECTION DIAGRAM

Plastic DIP (N),
Small Outline (R) and
Cerdip (Q) Packages


NC = NO CONNECT
specifications which include an open-loop gain of $3500 \mathrm{~V} / \mathrm{V}$ ( 500 $\Omega$ load) and low input offset voltage of 0.5 mV . Common-mode rejection is a minimum of 78 dB . Output voltage swing is $\pm 3 \mathrm{~V}$ into loads as low as $150 \Omega$. Analog Devices also offers over 30 other high speed amplifiers from the low noise AD829 (1.7. $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ ) to the ultimate video amplifier, the AD811, which features $0.01 \%$ differential gain and $0.01^{\circ}$ differential phase.

## APPLICATION HIGHLIGHTS

1. As a buffer the AD847 offers a full-power bandwidth of 12.7 MHz ( 5 V p-p with $\pm 5 \mathrm{~V}$ supplies) making it outstanding as an input buffer for flash A/D converters.
2. The low power and small outline package of the AD847 make it very well suited for high density applications such as multiple pole active filters.
3. The AD847 is internally compensated for unity gain operation and remains stable when driving any capacitive load.


AD847 Driving Capacitive Loads


[^154]AD847


| $S^{1}$ |
| :---: |
| Supply Voltage |
| Internal Power Dissipation ${ }^{2}$ |
| Plastic (N) . . . . . . . . . . . . . . . . . . . . . . . 1.2 Watts |
| Small Outline (R) . . . . . . . . . . . . . . . . . . . . 0.8 Watts |
| Cerdip (Q) . . . . . . . . . . . . . . . . . . . . . . . . 1.1 Watts |
| Input Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm \mathrm{V}_{\text {S }}$ |
| Differential Input Voltage . . . . . . . . . . . . . . . . . . . . . $\pm 6 \mathrm{~V}$ |
| Storage Temperature Range (Q) . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ <br> (N, R) . . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Junction Temperature . . . . . . . . . . . . . . . . . . . . . . $175^{\circ} \mathrm{C}$ |
| Lead Temperature Range (Soldering 60 sec ) . . . . . . . . $300^{\circ} \mathrm{C}$ |
| NOTES |
| ${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. <br> ${ }^{2}$ Mini-DIP Package: $\theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} / \mathrm{Watt} ; \theta_{\mathrm{JC}}=33^{\circ} \mathrm{C} /$ Watt Cerdip Package: $\theta_{\mathrm{JA}}=110^{\circ} \mathrm{C} / \mathrm{W}$ att; $\theta_{\mathrm{JC}}=30^{\circ} \mathrm{C} / \mathrm{Watt}$ <br> Small Outline Package: $\theta_{\mathrm{JA}}=155^{\circ} \mathrm{C} / \mathrm{Watt} ; \theta_{\mathrm{JC}}=33^{\circ} \mathrm{C} / \mathrm{Watt}$ |
|  |  |
|  |  |
|  |  |

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

## ESD SUSCEPTIBILITY

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 volts, which readily accumulate on the human body and on test equipment, can discharge without detection. Although the AD847 features proprietary ESD protection circuitry, permanent damage may still occur on these devices if they are subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid any performance degradation or loss of functionality.

## METALIZATION PHOTOGRAPH

Contact factory for latest dimensions.
Dimensions shown in inches and (mm).


ORDERING GUIDE

| Model $^{\mathbf{1}}$ | Temperature <br> Range $-{ }^{\circ} \mathbf{C}$ | Package <br> Description | Package <br> Option $^{2}$ |
| :--- | :--- | :--- | :--- |
| AD847JN | 0 to +70 | Plastic | N-8 |
| AD847JR | 0 to +70 | SOIC | R-8 |
| AD847AQ | -40 to +85 | Cerdip | Q-8 |
| AD847AR | -40 to +85 | SOIC | R-8 |
| AD847SQ | -55 to +125 | Cerdip | Q-8 |
| AD847SQ/883B | -55 to +125 | Cerdip | Q-8 |
| 5962-8964701PA | -55 to +125 | Cerdip | Q-8 |

[^155]
## FEATURES

725MHz Gain Bandwidth - AD849
175MHz Gain Bandwidth - AD848
4.8mA Supply Current

300V/ $\mu \mathrm{s}$ Slew Rate
80ns Settling Time to 0.1\% for a 10V Step - AD849
Differential Gain: AD848 = 0.07\%, AD849 = 0.08\%
Differential Phase: AD848 $=0.08^{\circ}$, AD849 $=0.04^{\circ}$
Drives Capacitive Loads
DC PERFORMANCE
$3 n V / \sqrt{H z}$ Input Voltage Noise - AD849
85V/mV Open Loop Gain into a $1 \mathrm{k} \Omega$ Load - AD849
1mV max Input Offset Voltage
Performance Specified for $\pm 5 \mathrm{~V}$ and $\pm 15 \mathrm{~V}$ Operation
Available in Plastic, Hermetic Cerdip and Small Outline
Packages. Chips and MIL-STD-883B Parts Available.
Available in Tape and Reel in Accordance with
EIA-481A Standard

## APPLICATIONS

## Cable Drivers

8- and 10-Bit Data Acquisition Systems
Video and $R_{F}$ Amplification
Signal Generators

## PRODUCT DESCRIPTION

The AD848 and AD849 are high speed, low power monolithic operational amplifiers. The AD848 is internally compensated so that it is stable for closed loop gains of 5 or greater. The AD849 is fully decompensated and is stable at gains greater than 24. The AD848 and AD849 achieve their combination of fast ac and good dc performance by utilizing Analog Devices' junction isolated complementary bipolar (CB) process. This process enables these op amps to achieve their high speed while only requiring 4.8 mA of current from the power supplies.

The AD848 and AD849 are members of Analog Devices' family of high speed op amps. This family includes, among others, the AD847 which is unity gain stable, with a gain bandwidth of 50 MHz . For more demanding applications, the AD840, AD841 and AD842 offer even greater precision and greater output current drive.
The AD848 and AD849 have good dc performance. When operating with $\pm 5 \mathrm{~V}$ supplies, they offer open loop gains of $13 \mathrm{~V} / \mathrm{mV}$ (AD848 with a $500 \Omega$ load) and low input offset voltage of 1 mV maximum. Common-mode rejection is a minimum of 92 dB . Output voltage swing is $\pm 3 \mathrm{~V}$ even into loads as low as $150 \Omega$.

## CONNECTION DIAGRAMS

Plastic (N), Small Outline (R) and Cerdip (Q) Packages


20-Terminal LCC Pinout


## APPLICATIONS HIGHLIGHTS

1. The high slew rate and fast settling time of the AD848 and AD849 make them ideal for video instrumentation circuitry, low noise pre-amps and line drivers.
2. In order to meet the needs of both video and data acquisition applications, the AD848 and AD849 are optimized and tested for $\pm 5 \mathrm{~V}$ and $\pm 15 \mathrm{~V}$ power supply operation.
3. Both amplifiers offer full power bandwidth greater than 20 MHz (for 2 V p-p with $\pm 5 \mathrm{~V}$ supplies).
4. The AD848 and AD849 remain stable when driving any capacitive load.
5. Laser wafer trimming reduces the input offset voltage to 1 mV maximum on all grades, thus eliminating the need for external offset nulling in many applications.
6. The AD848 is an enhanced replacement for the LM6164 series and can function as a pin-for-pin replacement for many high speed amplifiers such as the HA2520/2/5 and EL2020 in applications where the gain is 5 or greater.
[^156]SPESIFIGATONS $\left(@ T_{A}=+25^{\circ} \mathrm{C}\right.$, unless otherwise noted)


## NOTES

${ }^{1}$ Input offset voltage specifications are guaranteed after 5 minutes at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.
${ }^{2}$ Full power bandwidth $=$ slew rate $/ 2 \pi V_{\text {PEAK }}$. Refer to Figure 1.
All min and max specifications are guaranteed. Specifications in boldface are tested on all production units at final electrical test. All others are guaranteed but not necessarily tested.
Specifications subject to change without notice.


## NOTES

${ }^{1}$ Input offset voltage specifications are guaranteed after 5 minutes at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.
${ }^{2}$ Full power bandwidth $=$ slew rate $/ 2 \pi \mathrm{~V}_{\text {PEAK }}$. Refer to Figure 1.
All min and max specifications are guaranteed. Specifications in boldface are tested on all production units at final electrical test. All others are guaranteed but not necessarily tested.
Specifications subject to change without notice.

ABSOLUTE MAXIMUM RATINGS ${ }^{1}$


METALIZATION PHOTOGRAPH
Contact factory for latest dimensions. (AD848 and AD849 are identical except for the part number in the upper right.) Dimensions shown in inches and (mm).


## ORDERING GUIDE

| Model | Gain <br> Bandwidth $\mathbf{M H z}$ | Min <br> Stable <br> Gain | Max <br> Offset Voltage mV | Temperature <br> Range - ${ }^{\circ} \mathrm{C}$ | Package Option ${ }^{1}$ |
| :---: | :---: | :---: | :---: | :---: | :---: |
| AD848JN | 175 | 5 | 1 | 0 to +70 | N-8 |
| AD848JR ${ }^{2}$ | 175 | 5 | 1 | 0 to +70 | R-8 |
| AD848JCHIPS | 175 | 5 | 1 | 0 to +70 | Die Form |
| AD848AQ | 175 | 5 | 1 | -40 to +85 | Q-8 |
| AD848SQ | 175 | 5 | 1 | -55 to +125 | Q-8 |
| AD848SQ/883B | 175 | 5 | 1 | -55 to +125 | Q-8 |
| AD848SE/883B | 175 | 5 | 1 | -55 to +125 | E-20A |
| AD849JN | 725 | 25 | 1 | 0 to +70 | N-8 |
| AD849JR ${ }^{2}$ | 725 | 25 | 1 | 0 to +70 | R-8 |
| AD849AQ | 725 | 25 | 0.75 | -40 to +85 | Q-8 |
| AD849SQ | 725 | 25 | 0.75 | -55 to +125 | Q-8 |
| AD849SQ/883B | 725 | 25 | 0.75 | -55 to +125 | Q-8 |
| AD847J/A/S | 50 | 1 | 1 | See AD847 | ata Sheet |

NOTES
${ }^{1} \mathrm{E}=$ LCC; $\mathrm{N}=$ Plastic DIP; $\mathrm{Q}=$ Cerdip; R = Small Outline IC (SOIC). For outline information see
Package Information section.
${ }^{2}$ Plastic SOIC (R) available in tape and reel. AD848 available in S grade chips. AD849 available in $J$ and $S$ grade chips.


## FEATURES

Improved Replacement for Signetics SE/NE5539

## AC PERFORMANCE

Gain Bandwidth Product: 1.4 GHz typ
Unity Gain Bandwidth: 220 MHz typ
High Slew Rate: 600 V/us typ
Full Power Response: 82 MHz typ
Open-Loop Gain: 47 dB min, 52 dB typ
DC PERFORMANCE
All Guaranteed DC Specifications Are 100\% Tested For Each Device Over Its Full Temperature Range - For All Grades and Packages
$\mathbf{V}_{\mathbf{o s}}: 5 \mathbf{~ m V}$ max Over Full Temperature Range (AD5539S)
$\mathrm{I}_{\mathrm{B}}: \mathbf{2 0 \mu \mathrm { A } \operatorname { m a x }}$ (AD5539J)

PSRR: $100 \mu \mathrm{~V} / \mathrm{V}$ typ
MIL-STD-883B Parts Available

## PRODUCT DESCRIPTION

The AD5539 is an ultrahigh frequency operational amplifier designed specifically for use in video circuits and RF amplifiers. Requiring no external compensation for gains greater than 5 , it may be operated at lower gains with the addition of external compensation.
As a superior replacement for the Signetics NE/SE5539, each AD5539 is $100 \%$ dc tested to meet all of its guaranteed dc specifications over the full temperature range of the device.
The high slew rate and wide bandwidth of the AD5539 provide low cost solutions to many otherwise complex and expensive high frequency circuit design problems.
The AD5539 is available specified to operate over either the commercial (AD5539JN/JQ) or military (AD5539SQ) temperature range. The commercial grade is available either in 14-pin plastic or cerdip packages. The military version is supplied in the cerdip package. Chip versions are also available.

## PRODUCT HIGHLIGHTS

1. All guaranteed dc specifications are $100 \%$ tested.
2. The AD5539 drives $50 \Omega$ and $75 \Omega$ loads directly.
3. Input voltage noise is less than $4 \mathrm{nV} \sqrt{\mathrm{Hz}}$.
4. Low cost RF and video speed performance.
5. $\pm 2$ volt output range into a $150 \Omega$ load.
6. Low cost.
7. Chips available.
[^157]SDEMFMGAONS ( $+25^{\circ} \mathrm{C}$ and $\mathrm{V}_{\mathrm{S}}= \pm 8 \mathrm{~V}$ dc, unless otherwise noted)
AD5539

| Parameter | AD5539J |  |  | AD5539S |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max |  |
| INPUT OFFSET VOLTAGE <br> Initial Offset ${ }^{1}$ <br> $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ |  | 2 | $\begin{aligned} & 5 \\ & 6 \end{aligned}$ |  | 2 | $\begin{aligned} & 3 \\ & 5 \end{aligned}$ | $\begin{aligned} & \mathrm{mV} \\ & \mathrm{mV} \end{aligned}$ |
|  |  | 0.1 | $\begin{aligned} & 2 \\ & 5 \end{aligned}$ |  | 0.1 | $\begin{aligned} & 1 \\ & 3 \end{aligned}$ | $\underset{\mu \mathrm{A}}{\mu \mathrm{~A}}$ |
| ```INPUT BIAS CURRENT Initial \({ }^{2}\) \(\mathrm{V}_{\mathrm{CM}}=0\) Either Input \(T_{\text {min }}\) to \(T_{\text {max }}\)``` |  |  | $\begin{aligned} & 20 \\ & 40 \end{aligned}$ |  |  | $\begin{aligned} & 13 \\ & 25 \end{aligned}$ | $\mu \mathrm{A}$ $\mu \mathrm{A}$ |
| ```FREQUENCY RESPONSE \(\mathrm{R}_{\mathrm{L}}=150 \Omega^{3}\) Small Signal Bandwidth \(\mathrm{A}_{\mathrm{CL}}=2^{4}\) Gain Bandwidth Product \(\mathrm{A}_{\mathrm{CL}}=26 \mathrm{~dB}\) Full Power Response \(A_{c L}=2^{4}\) \(\mathrm{A}_{\mathrm{CL}}=7\) \(\mathrm{A}_{\mathrm{CL}}=20\) Settling Time ( \(1 \%\) ) Slew Rate Large Signal Propagation Delay Total Harmonic Distortion \(\mathrm{R}_{\mathrm{L}}=\infty\) \(\mathrm{R}_{\mathrm{L}}=100 \Omega^{3}\) \(\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}_{\mathrm{p}-\mathrm{p}}\) \(\mathrm{A}_{\mathrm{CL}}=7, \mathrm{f}=1 \mathrm{kHz}\)``` |  | $\begin{aligned} & 220 \\ & 1400 \\ & \\ & 68 \\ & 82 \\ & 65 \\ & 12 \\ & 600 \\ & 4 \\ & \\ & 0.010 \\ & 0.016 \end{aligned}$ |  |  | $\begin{aligned} & 220 \\ & \\ & 1400 \\ & \\ & 68 \\ & 82 \\ & 65 \\ & 12 \\ & 600 \\ & 4 \\ & \\ & 0.010 \\ & 0.016 \end{aligned}$ |  | MHz <br> MHz <br> MHz <br> MHz <br> MHz <br> ns <br> V/us <br> ns <br> \% <br> \% |
| INPUT IMPEDANCE |  | 100 |  |  | 100 |  | k $\Omega$ |
| OUTPUT IMPEDANCE ( $\mathrm{f}<10 \mathrm{MHz}$ ) |  | 2 |  |  | 2 |  | $\Omega$ |
| INPUT VOLTAGE RANGE <br> Differential ${ }^{5}$ <br> (Max Nondestructive) <br> Common-Mode Voltage <br> (Max Nondestructive) <br> Common-Mode Rejection Ratio $\begin{aligned} & \Delta \mathrm{V}_{\mathrm{CM}}=1.7 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{s}}=100 \Omega \\ & \mathrm{~T}_{\text {min }} \text { to } \mathrm{T}_{\text {max }} \end{aligned}$ | $\begin{aligned} & 70 \\ & 60 \end{aligned}$ | 250 2.5 85 |  | $\begin{aligned} & 70 \\ & 60 \end{aligned}$ | 250 2.5 85 |  | $\begin{aligned} & \mathrm{mV} \\ & \mathrm{~V} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \end{aligned}$ |
| ```INPUT VOLTAGE NOISE Wideband RMS Noise (RTI) \(\mathrm{BW}=5 \mathrm{MHz} ; \mathrm{R}_{\mathrm{s}}=50 \Omega\) Spot Noise \(\mathrm{F}=1 \mathrm{kHz} ; \mathrm{R}_{\mathrm{s}}=50 \Omega\)``` |  | 5 4 |  |  | 5 4 |  | $\mu \mathrm{V}$ <br> $\mathrm{nV} \sqrt{\mathrm{Hz}}$ |
| OPEN-LOOP GAIN $\begin{aligned} & \mathrm{V}_{\mathrm{O}}=+2.3 \mathrm{~V},-1.7 \mathrm{~V} \\ & \mathbf{R}_{\mathrm{L}}=150 \Omega^{3} \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & \mathrm{~T}_{\min } \text { to } \mathrm{T}_{\max }-\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & \hline \end{aligned}$ | $\begin{aligned} & 47 \\ & 47 \\ & 43 \end{aligned}$ | 52 | $\begin{aligned} & 58 \\ & 58 \\ & 63 \\ & \hline \end{aligned}$ | $\begin{aligned} & 47 \\ & 48 \\ & 46 \end{aligned}$ | 52 | $\begin{aligned} & 58 \\ & 57 \\ & 60 \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \end{aligned}$ |

$\left.\begin{array}{l|cc|ccc|c}\hline \text { Parameter } & \text { Min } & \begin{array}{c}\text { AD5539J } \\ \text { Typ }\end{array} & \text { Max }\end{array}\right)$

## NOTES

${ }^{1}$ Input Offset Voltage specifications are guaranteed after 5 minutes of operation at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.
${ }^{2}$ Bias Current specifications are guaranteed maximum at either input after 5 minutes of operation at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.
${ }^{3} \mathrm{R}_{\mathrm{x}}=470 \Omega$ to $-\mathrm{V}_{\mathrm{S}}$.
${ }^{4}$ Externally compensated.
${ }^{5}$ Defined as voltage between inputs, such that neither exceeds $+2.5 \mathrm{~V},-5.0 \mathrm{~V}$ from ground.
${ }^{6}$ For outline information see Package Information section.
Specifications subject to change without notice.
Specifications in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

|  |  |
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## OFFSET NULL CONFIGURATION



OUTPUT NULL RANGE $\cong+V_{\mathbf{S}}\left(\frac{\mathbf{R}_{\mathbf{F}}}{\mathbf{R}_{\text {NULL }}}\right)$ TO $-\mathbf{V}_{\mathbf{S}}\left(\frac{\mathbf{R}_{\mathbf{F}}}{\mathbf{R}_{\text {NULL }}}\right)$
OFFSET NULL CONFIGURATION

FEATURES
Excellent Video Specifications ( $\mathrm{R}_{\mathrm{L}}=150 \Omega, \mathbf{G}=\boldsymbol{+ 2}$ )
Gain Flatness 0.1 dB to $100 \mathbf{M H z}$
0.01\% Differential Gain Error
$0.025^{\circ}$ Differential Phase Error

## Low Power

5.5 mA max Power Supply Current ( 55 mW )

High Speed and Fast Settling
$880 \mathrm{MHz},-3 \mathrm{~dB}$ Bandwidth ( $\mathrm{G}=+1$ )
$440 \mathrm{MHz},-3 \mathrm{~dB}$ Bandwidth ( $\mathbf{G}=+2$ )
1200 V/ $\mu \mathrm{s}$ Slew Rate
10 ns Settling Time to 0.1\%
Low Distortion
-65 dBc THD , $\mathrm{f}_{\mathrm{c}}=5 \mathrm{MHz}$
33 dBm 3 rd Order Intercept, $\mathrm{F}_{1}=\mathbf{1 0} \mathbf{~ M H z}$
-66 dB SFDR, f=5 MHz
High Output Drive

## 70 mA Output Current

Drives Up to 4 Back-Terminated Loads ( $75 \Omega$ Each) While Maintaining Good Differential Gain/Phase Performance (0.05\%/0.25 ${ }^{\circ}$ )

## APPLICATIONS

A-to-D Driver
Video Line Driver
Professional Cameras
Video Switchers
Special Effects
RF Receivers

## PRODUCT DESCRIPTION

The AD8001 is a low power, high speed amplifier designed to operate on $\pm 5 \mathrm{~V}$ supplies. The AD8001 features unique


Figure 1. Frequency Response of AD8001

FUNCTIONAL BLOCK DIAGRAM
8-Pin Plastic Mini-DIP and SOIC

transimpedance linearization circuitry. This allows it to drive video loads with excellent differential gain and phase performance on only 50 mW of power. The AD 8001 is a current feedback amplifier and features gain flatness of 0.1 dB to 100 MHz while offering differential gain and phase error of $0.01 \%$ and $0.025^{\circ}$. This makes the AD8001 ideal for professional video electronics such as cameras and video switchers. Additionally, the AD8001's low distortion and fast settling make it ideal for buffer high speed A-to-D converters.
The AD8001 offers low power of $5.5 \mathrm{~mA} \max \left(\mathrm{~V}_{\mathrm{S}}= \pm 5 \mathrm{~V}\right)$ and can run on a single +12 V power supply, while being capable of delivering up to 70 mA of load current. All this is offered in a small 8-pin DIP or 8-pin SOIC package. These features make this amplifier ideal for portable and battery powered applications where size and power is critical.
The outstanding bandwidth of 800 MHz along with $1200 \mathrm{~V} / \mu \mathrm{s}$ of slew rate make the AD8001 useful in many general purpose high speed applications where dual power supplies of up to $\pm 6 \mathrm{~V}$ and single supplies from 6 V to 12 V are needed. The AD8001 is available in the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.


Figure 2. Transient Response of AD8001; 2 V Step, $G=+2$

## AD8ODA-SPEGFFGATIONS $\left(@ T_{A}=+25^{\circ} \mathrm{C}, \mathrm{v}_{\mathrm{S}}= \pm 5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=100 \Omega\right.$, unless otherwise noted)

| Model |  |  | AD800 |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | Conditions | Min | Typ | Max | Units |
| DYNAMIC PERFORMANCE |  |  |  |  |  |
| -3 dB Small Signal Bandwidth, N Package | $\mathrm{G}=+2,<0.1 \mathrm{~dB}$ Peaking, $\mathrm{R}_{\mathrm{F}}=750 \Omega$ | 350 | 440 |  | MHz |
|  | $\mathrm{G}=+1,<1 \mathrm{~dB}$ Peaking, $\mathrm{R}_{\mathrm{F}}=1 \mathrm{k} \Omega$ | 650 | 880 |  | MHz |
| R Package | $G=+2,<0.1 \mathrm{~dB}$ Peaking, $\mathrm{R}_{\mathrm{F}}=681 \Omega$ | 350 | 440 |  | MHz |
|  | $\mathrm{G}=+1,<0.1 \mathrm{~dB}$ Peaking, $\mathrm{R}_{\mathrm{F}}=845 \Omega$ | 575 | 715 |  | MHz |
| Bandwidth for 0.1 dB Flatness |  |  |  |  |  |
| N Package | $\mathrm{G}=+2, \mathrm{R}_{\mathrm{F}}=750 \Omega$ | 85 | 110 |  | MHz |
| R Package | $\mathrm{G}=+2, \mathrm{R}_{\mathrm{F}}=681 \Omega$ | 100 | 125 |  | MHz |
| Slew Rate | $\mathrm{G}=+2, \mathrm{~V}_{\mathrm{O}}=2 \mathrm{~V}$ Step | 800 | 1000 |  | V/ $/ \mathrm{s}$ |
|  | $\mathrm{G}=-1, \mathrm{~V}_{\mathrm{O}}=2 \mathrm{~V}$ Step | 960 | 1200 |  | V/ $/ \mathrm{s}$ |
| Settling Time to 0.1\% | $\mathrm{G}=-1, \mathrm{~V}_{\mathrm{O}}=2 \mathrm{~V}$ Step |  | 10 |  | ns |
| Rise \& Fall Time | $\mathrm{G}=-1, \mathrm{~V}_{\mathrm{O}}=2 \mathrm{~V}$ Step, $\mathrm{R}_{\mathrm{F}}=649 \Omega$ |  | 1.4 |  | ns |
| NOISE/HARMONIC PERFORMANCE |  |  |  |  |  |
| Total Harmonic Distortion | $\mathrm{f}_{\mathrm{C}}=5 \mathrm{MHz}, \mathrm{V}_{\mathrm{O}}=2 \mathrm{~V} \mathrm{p}-\mathrm{p}$ |  | -65 |  | dBc |
|  | $\mathrm{G}=+2, \mathrm{R}_{\mathrm{L}}=100 \Omega$ |  |  |  |  |
| Input Voltage Noise | $\mathrm{f}=10 \mathrm{kHz}$ |  | 2.0 |  | n $\mathrm{V} / \sqrt{\mathrm{Hz}}$ |
| Input Current Noise | $\mathrm{f}=10 \mathrm{kHz},+\mathrm{In}$ |  | 2.0 |  | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
|  | -In |  | 18 |  | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
| Differential Gain Error | NTSC, $\mathrm{G}=+2, \mathrm{R}_{\mathrm{L}}=150 \Omega$ |  | 0.01 | 0.025 | \% |
| Differential Phase Error | NTSC, $\mathrm{G}=+2, \mathrm{R}_{\mathrm{L}}=150 \Omega$ |  | 0.025 | 0.04 | Degree |
| Third Order Intercept | $\mathrm{f}=10 \mathrm{MHz}$ |  | 33 |  | dBm |
| 1 dB Gain Compression | $\mathrm{f}=10 \mathrm{MHz}$ |  | 14 |  | dBm |
| SFDR | $\mathrm{f}=5 \mathrm{MHz}$ |  | -66 |  | dB |
| DC PERFORMANCE |  |  |  |  |  |
| Input Offset Voltage |  |  | 2.0 | 5.5 | mV |
|  | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ |  | 2.0 | 9.0 | mV |
| Offset Drift |  |  | 10 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| -Input Bias Current |  |  | 5.0 | 25 | $\pm \mu \mathrm{A}$ |
|  | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ |  |  | 35 | $\pm \mu \mathrm{A}$ |
| +Input Bias Current |  |  | 3.0 | 6.0 | $\pm \mu \mathrm{A}$ |
|  | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ |  |  | 10 | $\pm \mu \mathrm{A}$ |
| Open Loop Transresistance | $\mathrm{V}_{\mathrm{O}}= \pm 2.5 \mathrm{~V}$ | 250 | 900 |  | $\mathrm{k} \Omega$ |
|  | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ | 175 |  |  | $\mathrm{k} \Omega$ |
| INPUT CHARACTERISTICS |  |  |  |  |  |
| Input Resistance | +Input |  | 10 |  | M $\Omega$ |
| . . . . ... | -Input |  | 50 |  | $\Omega$ |
| Input Capacitance | +Input |  | 1.5 |  | pF |
| Input Common-Mode Voltage Range |  |  | 3.2 |  | $\pm \mathrm{V}$ |
| Common-Mode Rejection Ratio |  |  |  |  |  |
| Offset Voltage | $\mathrm{V}_{\mathrm{CM}}= \pm 2.5 \mathrm{~V}$ | 50 | 54 |  | dB |
| -Input Current | $\mathrm{V}_{\mathrm{CM}}= \pm 2.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{MIN}}-\mathrm{T}_{\mathrm{MAX}}$ |  | 0.3 | 1.0 | $\mu \mathrm{A} / \mathrm{V}$ |
| +Input Current | $\mathrm{V}_{\mathrm{CM}}= \pm 2.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{MIN}}-\mathrm{T}_{\mathrm{MAX}}$ |  | 0.2 | 0.7 | $\mu \mathrm{A} / \mathrm{V}$ |
| OUTPUT CHARACTERISTICS |  |  |  |  |  |
| Output Voltage Swing | $\mathrm{R}_{\mathrm{L}}=150 \Omega$ | 2.7 | 3.1 |  | $\pm \mathrm{V}$ |
| Output Current | $\mathrm{R}_{\mathrm{L}}=37.5 \Omega$ | 50 | 70 |  | mA |
| Short Circuit Current |  | 85 | 110 |  | mA |
| POWER SUPPLY |  |  |  |  |  |
| Operating Range |  | $\pm 3.0$ |  | $\pm 6.0$ | V |
| Quiescent Current | $\mathrm{T}_{\text {MIN }-} \mathrm{T}_{\text {MAX }}$ |  | 5.0 | 5.5 | mA |
| Power Supply Rejection Ratio | $+\mathrm{V}_{\mathrm{S}}=+4 \mathrm{~V}$ to $+6 \mathrm{~V},-\mathrm{V}_{\mathrm{S}}=-5 \mathrm{~V}$ | 60 | 75 |  | dB |
|  | $-\mathrm{V}_{\mathrm{S}}=-4 \mathrm{~V}$ to $-6 \mathrm{~V},+\mathrm{V}_{\text {S }}=+5 \mathrm{~V}$ | 50 | 56 |  | dB |
| -Input Current | $\mathrm{T}_{\text {MIN- }} \mathrm{T}_{\text {MAX }}$ |  | 0.5 | 2.5 | $\mu \mathrm{A} / \mathrm{V}$ |
| +Input Current | $\mathrm{T}_{\text {MIN }-} \mathrm{T}_{\text {MAX }}$ |  | 0.1 | 0.5 | $\mu \mathrm{A} / \mathrm{V}$ |

[^158]
## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 12.6 V
Internal Power Dissipation ${ }^{2}$
Plastic Package (N) . . . . . . . . . . . . . . . . . . . . . . . . . . 3 Watts
Small Outline Package (R) . . . . . . . . . . . . . . . . . . . 0.9 Watts
Input Voltage (Common Mode) . . . . . . . . . . . . . . . . . . . . $\pm \mathrm{V}_{\mathrm{S}}$
Differential Input Voltage . . . . . . . . . . . . . . . . . . . . . . . $\pm 1.2 \mathrm{~V}$
Output Short Circuit Duration
Observe Power Derating Curves
Storage Temperature Range N, R . . . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Operating Temperature Range (A Grade) ... $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Lead Temperature Range (Soldering 10 sec ) . . . . . . . $+300^{\circ} \mathrm{C}$

## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ Specification is for device in free air:
8-Pin Plastic Package: $\theta_{\mathrm{JA}}=90^{\circ} \mathrm{C} /$ Watt
8 -Pin SOIC Package: $\theta_{\mathrm{JA}}=140^{\circ} \mathrm{C} /$ Watt

## METALLIZATION PHOTO

Dimensions shown in inches and (mm).
Connect Substrate to $-V_{S}$.


## MAXIMUM POWER DISSIPATION

The maximum power that can be safely dissipated by the AD8001 is limited by the associated rise in junction temperature. The maximum safe junction temperature for plastic encapsulated devices is determined by the glass transition temperature of the plastic, approximately $+150^{\circ} \mathrm{C}$. Exceeding this limit temporarily may cause a shift in parametric performance due to a change in the stresses exerted on the die by the package. Exceeding a junction temperature of $+175^{\circ} \mathrm{C}$ for an extended period can result in device failure.
While the AD8001 is internally short circuit protected, this may not be sufficient to guarantee that the maximum junction temperature $\left(+150^{\circ} \mathrm{C}\right)$ is not exceeded under all conditions. To ensure proper operation, it is necessary to observe the maximum power derating curves.


Figure 3. Plot of Maximum Power Dissipation vs. Temperature

ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD8001AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | $\mathrm{N}-8$ |
| AD8001AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | $\mathrm{R}-8$ |
| AD8001ACHIPS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Die Form <br> AD8001SMD | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | | 8-Pin Cerdip |
| :--- |
| SOIC Eval Board, |
| AD8001R-EB $+2^{3}$ |

## NOTES

${ }^{1}$ For outline information see Package Information section.
${ }^{2}$ Standard Military Drawing Device. Ordering Number TBD. Contact our local sales office, representative or distributor for availability.
${ }^{3}$ Refer to Evaluation Board section.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD8001 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

## AD8001



Figure 4. Test Circuit, Gain $=+2$


Figure 5. 1 V Step Response, $G=+2$


Figure 6. $2 V$ Step Response, $G=+1$


Figure 7. $2 V$ Step Response, $G=+2$


Figure 8. Test Circuit, Gain $=+1$


Figure 9. 100 mV Step Response, $G=+1$


Figure 10. Frequency Response, $G=+2$


Figure 11. 0.1 dB Flatness, $R$ Package (for $N$ Package add $50 \Omega$ to $R_{F}$ )


Figure 12. Distortion vs. Frequency, $R_{L}=1 \mathrm{k} \Omega$


Figure 13. $-3 d B$ Bandwidth vs. $R_{F}$


Figure 14. Distortion vs. Frequency, $R_{L}=100 \Omega$


Figure 15. Differential Gain and Differential Phase


Figure 16. Frequency Response, $G=+1$


Figure 17. Flatness, R Package, $G=+1$ (for N Package Add $100 \Omega$ to $R_{F}$ )


Figure 18. Distortion vs. Frequency, $R_{L}=1 \mathrm{k} \Omega$


Figure 19. $-3 d B$ Bandwidth vs. $R_{F}, G=+1$


Figure 20. Distortion vs. Frequency, $R_{L}=100 \Omega$


Figure 21. Large Signal Frequency Response, $G=+1$


Figure 22. Frequency Response, $G=+10, G=+100$


Figure 23. Output Swing vs.Temperature


Figure 24. Input Bias Current vs. Temperature


Figure 25. Input Offset vs. Temperature


Figure 26. Supply Current vs. Temperature


Figure 27. Short Circuit Current vs. Temperature


Figure 28. Transresistance vs. Temperature


Figure 29. Noise vs. Frequency


Figure 30. CMRR vs. Temperature


Figure 31. Output Resistance vs. Frequency


Figure 32. $-3 d B$ Bandwidth vs. Frequency, $G=-1$


Figure 33. PSRR vs. Temperature


Figure 34. CMRR vs. Frequency


Figure 35. $-3 d B$ Bandwidth vs. Frequency, $G=-2$


Figure 36. 100 mV Step Response, $G=-1$


Figure 37. PSRR vs. Frequency


Figure 38. 2 V Step Response, $G=-1$


Figure 39. Input Offset Voltage Distribution

## THEORY OF OPERATION

A very simple analysis can put the operation of the AD8001, a current feedback amplifier, in familiar terms. Being a current feedback amplifier, the AD8001's open-loop behavior is expressed as transimpedance, $\Delta \mathrm{V}_{\mathrm{O}} / \Delta \mathrm{L}_{\mathrm{IN}}$, or $\mathrm{T}_{\mathrm{Z}}$. The open loop transimpedance behaves just as the open loop voltage gain of a voltage feedback amplifier, that is, it has a large dc value and decreases at roughly $6 \mathrm{~dB} /$ octave in frequency.

Since the $\mathrm{R}_{\mathrm{IN}}$ is proportional to $1 / \mathrm{g}_{\mathrm{M}}$, the equivalent voltage gain is just $T_{Z} \times g_{M}$, where the $g_{M}$ in question is the transconductance of the input stage. This results in a low open loop input impedance at the inverting input, a now familiar result. Using this amplifier as a follower with gain, Figure 40, basic analysis yields the following result.

$$
\begin{gathered}
\frac{V_{O}}{V_{I N}}=G \times \frac{T_{\mathrm{z}}(S)}{T_{\mathrm{z}}(S)+G \times R_{I N}+R_{1}} \\
G=1+\frac{R_{1}}{R_{2}} \quad R_{I N}=1 / g_{M} \approx 50 \Omega
\end{gathered}
$$

Recognizing that $G \times R_{I N} \ll R_{1}$ for low gains, it can be seen to the first order that bandwidth for this amplifier is independent of gain (G). This simple analysis in conjunction with Figure 41 in fact can predict the behavior of the AD8001 over a wide range of conditions.


Figure 40.

Considering that additional poles contribute excess phase at high frequencies there is a minimum feedback resistance below which peaking or oscillation may result. This fact is used to determine the optimum feedback resistance, $\mathrm{R}_{\mathrm{F}}$. In practice parasitic capacitance at Pin 2 will also add phase in the feedback loop, so picking an optimum value for $\mathrm{R}_{\mathrm{F}}$ can be difficult. Figure 42 illustrates this problem. Here the fine scale ( $0.1 \mathrm{~dB} / \mathrm{div}$ ) flatness is plotted vs. feedback resistance. These plots were taken using an evaluation card which is available to customers so that these results may readily duplicated (see Evaluation Board section).
Achieving and maintaining gain flatness of better than 0.1 dB at frequencies above 10 MHz requires careful consideration of several issues.


Figure 41. Transimpedance vs. Frequency


Figure 42. 0.1 dB Flatness vs. Frequency

## Choice of Feedback and Gain Resistors

Because of the above mentioned relationship between the bandwidth and the feedback resistor, the fine scale gain flatness will, to some extent, vary with feedback resistance. It, therefore, is recommended that once optimum resistor values have been determined, $1 \%$ tolerance values should be used if it is desired to maintain flatness over a wide range of production lots. In addition, resistors of different construction have different associated parasitic capacitance and inductance. Surface mount resistors were used for the bulk of the characterization for this data sheet. It is not recommended that leaded components be used with the AD8001.

## Printed Circuit Board Layout Considerations

As to be expected for a wideband amplifier, PC board parasitics can affect the overall closed loop performance. Of concern are stray capacitances at the output and the inverting input nodes. If a ground plane is to be used on the same side of the board as the signal traces, a space ( $5 \mathrm{~mm} \min$ ) should be left around the signal lines to minimize coupling. Additionally, signal lines connecting the feedback and gain resistors should be short enough so that their associated inductance does not cause high frequency gain errors. Line lengths on the order of less than 5 mm are recommended. If long runs of coaxial cable are being driven, dispersion and loss must be considered.

## Power Supply Bypassing

Adequate power supply bypassing can be critical when optimizing the performance of a high frequency circuit. Inductance in the power supply leads can form resonant circuits that produce peaking in the amplifier's response. In addition, if large current transients must be delivered to the load, then bypass capacitors (typically greater than $1 \mu \mathrm{~F}$ ) will be required to provide the best settling time and lowest distortion. A parallel combination at least $4.7 \mu \mathrm{~F}$ and between $0.1 \mu \mathrm{~F}$ and $0.01 \mu \mathrm{~F}$ is recommended. Some brands of electrolyic capacitors will require a small series damping resistor $\approx 4.7 \Omega$ for optimum results.

## DC Errors and Noise

There are three major noise and offset terms to consider in a current feedback amplifier. For offset errors refer to the equation below. For noise error the terms are root-sum-squared to give a net output error. In the circuit below (Figure 43) they are input offset $\left(\mathrm{V}_{\mathrm{IO}}\right)$ which appears at the output multiplied by the noise gain of the circuit ( $1+\mathrm{R}_{\mathrm{F}} / \mathrm{R}_{\mathrm{I}}$ ), Noninverting input current ( $\mathrm{I}_{\mathrm{BN}} \times \mathrm{R}_{\mathrm{N}}$ ) also multiplied by the noise gain, and the inverting input current, which when divided between $R_{F}$ and $R_{I}$ and subsequently multiplied by the noise gain always appears at the output as $\mathrm{I}_{\mathrm{BN}} \times \mathrm{R}_{\mathrm{F}}$. The input voltage noise of the AD8001 is a low $2 \mathrm{nV} / \sqrt{\mathrm{Hz}}$. At low gains though the inverting input current noise times $\mathrm{R}_{\mathrm{F}}$ is the dominant noise source. Careful layout and device matching contribute to better offset and drift specifications for the AD8001 compared to many other current feedback amplifiers. The typical performance curves in conjunction with the equations below can be used to predict the performance of the AD8001 in any application.

$$
V_{O U T}=V_{I O} \times\left(1+\frac{R_{F}}{R_{I}}\right) \pm I_{B N} \times R_{N} \times\left(1+\frac{R_{F}}{R_{I}}\right) \pm I_{B I} \times R_{F}
$$



Figure 43. Output Offset Voltage

## Driving Capacitive Loads

The AD8001 was designed primarily to drive nonreactive loads. If driving loads with a capacitive component is desired, best frequency response is obtained by the addition of a small series resistance as shown in Figure 44. The accompanying graph shows the optimum value for $\mathrm{R}_{\text {SERIES }}$ vs. capacitive load. It is worth noting that the frequency response of the circuit when driving large capacitive loads will be dominated by the passive roll-off of $\mathrm{R}_{\text {SERIES }}$ and $\mathrm{C}_{\mathrm{L}}$.


Figure 44. Driving Capacitive Loads


Figure 45. Recommended $R_{\text {SERIES }}$ vs. Capacitive Load

## Communications

Distortion is a key specification in communications applications. Intermodulation distortion (IMD) is a measure of the ability of an amplifier to pass complex signals without the generation of spurious harmonics. The third order products are usually the most problematic since several of them fall near the fundamentals and do not lend themselves to filtering. Theory predicts that the third order harmonic distortion components increase in power at three times the rate of the fundamental tones. The specification of third order intercept as the virtual point where fundamental and harmonic power are equal is one standard measure of distortion performance. Op amps used in closedloop applications do not always obey this simple theory. At a gain of two the AD8001 has performance summarized in Figure 46. Here the worst third order products are plotted vs. input power. The third order intercept of the AD8001 is +33 dBm at 10 MHz .


Figure 46. Third Order $I M D ; F_{1}=10 \mathrm{MHz}, F_{2}=12 \mathrm{MHz}$

## AD8001

## Operation as a Video Line Driver

The AD8001 has been designed to offer outstanding performance as a video line driver. The important specifications of differential gain $(0.01 \%)$ and differential phase $\left(0.025^{\circ}\right)$ meet the most exacting HDTV demands for driving one video load. The AD8001 also drives up to two back terminated loads, as shown in Figure 47, with equally impressive performance ( $0.01 \%$, $0.07^{\circ}$ ). Another important consideration is isolation between loads in a multiple load application. The AD8001 has more than 40 dB of isolation at 5 MHz when driving two $75 \Omega$ back terminated loads.


## Driving A-to-D Converters

The AD8001 is well suited for driving high speed analog-todigital converters such as the AD9058. The AD9058 is a dual 8bit 50 Msps ADC. In the circuit below two AD8001s are shown driving the inputs of the AD9058 which are configured for 0 V to +2 V ranges. Bipolar input signals are buffered, amplified $(-2 \times)$, and offset (by +1.0 V ) into the proper input range of the ADC. Using the AD9058's internal +2 V reference connected to both ADCs as shown in Figure 48 reduces the number of external components required to create a complete data acquisition system. The $20 \Omega$ resistors in series with ADC input are used to help the AD8001s drive the 10 pF ADC input capacitance. The two AD8001s only add 100 mW to the power consumption while not limiting the performance of the circuit

## Layout Considerations

The specified high speed performance of the AD8001 requires careful attention to board layout and component selection. Proper RF design techniques and low parasitic component selection are mandatory.
The PCB should have a ground plane covering all unused portions of the component side of the board to provide a low impedance ground path. The ground plane should be removed from the area near the input pins to reduce stray capacitance.


Figure 48. AD8001 Driving a Dual A-to-D Converter

Chip capacitors should be used for supply bypassing (see Figure 49). One end should be connected to the ground plane and the other within $1 / 8 \mathrm{in}$. of each power pin. An additional large ( $4.7 \mu \mathrm{~F}-10 \mu \mathrm{~F}$ ) tantalum electrolytic capacitor should be connected in parallel, but not necessarily so close, to supply current for fast, large-signal changes at the output.
The feedback resistor should be located close to the inverting input pin in order to keep the stray capacitance at this node to a minimum. Capacitance variations of less than 1 pF at the inverting input will significantly affect high speed performance.
Stripline design techniques should be used for long signal traces
(greater than about 1 in .). These should be designed with a characteristic impedance of $50 \Omega$ or $75 \Omega$ and be properly terminated at each end.

Evaluation Board
An evaluation board for the AD8001 is available that has been carefully laid-out and tested to demonstrate that the specified high speed performance of the device can be realized. For ordering information, please refer to the Ordering Guide.
The layout of the evaluation board can be used as shown or serve as a guide for a board layout.


Figure 49. Inverting and Noninverting Configurations for Evaluation Boards

Table I. Recommended Component Values

|  | $\begin{aligned} & \text { AD8001AN (DIP) } \\ & \text { Gain } \end{aligned}$ |  |  |  |  | AD8001AR (SOIC)Gain |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Component | -1 | +1 | +2 | +10 | +100 | -1 | +1 | +2 | +10 | +100 |
| $\mathrm{R}_{\mathrm{F}}$ | $649 \Omega$ | $1050 \Omega$ | $750 \Omega$ | $470 \Omega$ | $1000 \Omega$ | $604 \Omega$ | $953 \Omega$ | $681 \Omega$ | $470 \Omega$ | $1000 \Omega$ |
| $\mathrm{R}_{\mathrm{G}}$ | $649 \Omega$ | - | $750 \Omega$ | $51 \Omega$ | $10 \Omega$ | $604 \Omega$ | - | $681 \Omega$ | $51 \Omega$ | $10 \Omega$ |
| $\mathrm{R}_{\mathrm{O}}$ (Nominal) | $49.9 \Omega$ | $49.9 \Omega$ | 49.9 ת | 49.9 ת | $49.9 \Omega$ | $49.9 \Omega$ | $49.9 \Omega$ | 49.9 ת | $49.9 \Omega$ | $49.9 \Omega$ |
| $\mathrm{R}_{\mathrm{S}}$ | $0 \Omega$ | - | - | - | - | $0 \Omega$ | - | - | - | - |
| $\mathrm{R}_{\mathrm{T}}$ (Nominal) | $54.9 \Omega$ | 49.9 ת | 49.9 ת | 49.9 ת | $49.9 \Omega$ | $54.9 \Omega$ | $49.9 \Omega$ | 49.9 ת | $49.9 \Omega$ | $49.9 \Omega$ |
| Small Signal BW (MHz) | 340 | 880 | 460 | 260 | 20 | 370 | 710 | 440 | 260 | 20 |
| 0.1 dB Flatness (MHz) | 105 | 70 | 105 | - | - | 130 | 100 | 120 | - | - |



SOIC (R) NONINVERTER
Figure 50. Evaluation Board Silkscreen (Top)


SOIC (R) NONINVERTER
Figure 51. Evaluation Board Layout (Solder Side)


SOIC (R) NONINVERTER
Figure 52. Evaluation Board Layout (Component Side)

Dual $800 \mathrm{MHz}, 50 \mathrm{~mW}$ Current Feedback Amplifier

## FEATURES

Excellent Video Specifications ( $\mathrm{R}_{\mathrm{L}}=\mathbf{1 5 0} \Omega, \mathbf{G}=+\mathbf{2}$ )
Gain Flatness $\mathbf{0 . 1} \mathbf{~ d B}$ to $\mathbf{1 0 0} \mathbf{~ M H z}$
0.01\% Differential Gain Error
$0.025^{\circ}$ Differential Phase Error
Low Power
$5.5 \mathrm{~mA} /$ Amp max Power Supply Current ( 55 mW )
High Speed and Fast Settling
$880 \mathrm{MHz},-3 \mathrm{~dB}$ Bandwidth ( $\mathbf{G}=+1$ )
$440 \mathrm{MHz},-3 \mathrm{~dB}$ Bandwidth ( $\mathbf{G}=+2$ )
1200 V/ $\mu \mathrm{s}$ Slew Rate
10 ns Settling Time to 0.1\%
Low Distortion
-65 dBc THD, $\mathrm{f}_{\mathrm{c}}=5 \mathrm{MHz}$
33 dBm 3rd Order Intercept, $\mathrm{F}_{1}=10 \mathrm{MHz}$
-66 dB SFDR, $f=5 \mathrm{MHz}$
$\mathbf{- 6 0 ~ d B}$ Crosstalk, $f=\mathbf{5 M H z}$
High Output Drive
70 mA Output Current
Drives Up to 8 Back-Terminated Loads (75 $\Omega$ Each) While Maintaining Good Differential Gain/Phase Performance ( $0.05 \% / 0.25^{\circ}$ )
Available in Small 8-Pin PDIP or SOIC
APPLICATIONS
A-to-D Driver
Video Line Driver
Professional Cameras
Video Switchers
Special Effects
RF Receivers

## PRODUCT DESCRIPTION

The AD8002 is a dual, low power, high speed amplifier designed to operate on $\pm 5 \mathrm{~V}$ supplies. The AD8002 features


Figure 1. Frequency Response of AD8002

This is a preliminary data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

## FUNCTIONAL BLOCK DIAGRAM

8-Pin Plastic Mini-DIP and SOIC

unique transimpedance linearization circuitry. This allows it to drive video loads with excellent differential gain and phase performance on only 50 mW of power per amplifier. The AD8002 is a current feedback amplifier and features gain flatness of 0.1 dB to 100 MHz while offering differential gain and phase error of $0.01 \%$ and $0.025^{\circ}$. This makes the AD8002 ideal for professional video electronics such as cameras and video switchers. Additionally, the AD8002's low distortion and fast settling make it ideal for buffer high speed A-to-D converters.
The AD8002 offers low power of 5.5 mA /amplifier max $\left(\mathrm{V}_{\mathrm{S}}=\right.$ $\pm 5 \mathrm{~V}$ ) and can run on a single +12 V power supply, while being capable of delivering up to 70 mA of load current. All this is offered in a small 8-pin DIP or 8-pin SOIC package. These features make this amplifier ideal for portable and battery powered applications where size and power is critical.
The outstanding bandwidth of 800 MHz along with $1200 \mathrm{~V} / \mu \mathrm{s}$ of slew rate make the AD8002 useful in many general purpose high speed applications where dual power supplies of up to $\pm 6 \mathrm{~V}$ and single supplies from 6 V to 12 V are needed. The AD8002 is available in the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.


Figure 2. Transient Response of AD8002; 2 V Step, $G=+2$

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.


## NOTES

${ }^{1}$ Output current is limited by the maximum power dissipation in the package. See the power derating curves.
Specifications subject to change without notice.
This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.
ABSOLUTE MAXIMUM RATINGS ${ }^{1}$
Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 12.6 V
Internal Power Dissipation ${ }^{2}$
Plastic Package (N) . . . . . . . . . . . . . . . . . . . . . . . . . . 1.3 Watts
Small Outline Package (R) . . . . . . . . . . . . . . . . . . . 0.9 Watts
Input Voltage (Common Mode) . . . . . . . . . . . . . . . . . . . . $\pm \mathrm{V}_{\mathrm{S}}$
Differential Input Voltage ............................. $\pm 1.2 \mathrm{~V}$
Output Short Circuit Duration

| Storage Temperature Range N, Operating Temperature Range Lead Temperature Range (Sold |  |
| :---: | :---: |
|  |  |
|  |  |
|  |  |

## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indjcated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. ${ }^{2}$ Specification is for device in free air:
8 -Pin Plastic Package: $\theta_{\mathrm{JA}}=90^{\circ} \mathrm{C} / \mathrm{W}$ att
8 -Pin SOIC Package: $\theta_{\mathrm{JA}}=140^{\circ} \mathrm{C} /$ Watt

ORDERING GUIDE

| Model | Temperature <br> Range | Package Option ${ }^{\star}$ |
| :--- | :--- | :--- |
| AD8002AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP |
| AD8002AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC |

*For outline information see Package Information section.

## MAXIMUM POWER DISSIPATION

The maximum power that can be safely dissipated by the AD8002 is limited by the associated rise in junction temperature. The maximum safe junction temperature for plastic encapsulated devices is determined by the glass transition temperature of the plastic, approximately $+150^{\circ} \mathrm{C}$. Exceeding this limit temporarily may cause a shift in parametric performance due to a change in the stresses exerted on the die by the package. Exceeding a junction temperature of $+175^{\circ} \mathrm{C}$ for an extended period can result in device failure.

While the AD8002 is internally short circuit protected, this may not be sufficient to guarantee that the maximum junction temperature $\left(+150^{\circ} \mathrm{C}\right)$ is not exceeded under all conditions. To ensure proper operation, it is necessary to observe the maximum power derating curves.


Figure 3. Plot of Maximum Power Dissipation vs. Temperature

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD8002 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


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Figure 4. Test Circuit, Gain $=+2$


Figure 7. 2 V Step Response, $G=+2$


Figure 5. 1 V Step Response, $G=+2$


Figure 6. 2 V Step Response, $G=+1$


Figure 9. 100 mV Step Response, $G=+1$

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Figure 10. Frequency Response, $G=+2$


Figure 11. $0.1 d B$ Flatness, $R$ Package (for $N$ Package Add $50 \Omega$ to $R_{F}$ )


Figure 13. Crosstalk (Output-to-Output) vs. Frequency


Figure 14. Distortion vs. Frequency, $R_{L}=100 \Omega$


Figure 15. Differential Gain and Differential Phase

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Figure 16. Frequency Response, $G=+1$


Figure 17. Flatness, R Package, $G=+1$ (for N Package Add $100 \Omega$ to $R_{F}$ )


Figure 18. Distortion vs. Frequency, $R_{L}=1 \mathrm{k} \Omega$


Figure 19. Large Signal Frequency Response, $G=+2$


Figure 20. Distortion vs. Frequency, $R_{L}=100 \Omega$


Figure 21. Large Signal Frequency Response, $G=+1$

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Figure 22. Frequency Response, $G=+10, G=+100$


Figure 23. Output Swing vs. Temperature


Figure 24. Input Bias Current vs. Temperature


Figure 25. Input Offset vs. Temperature


Figure 26. Supply Current vs. Temperature


Figure 27. Short Circuit Current vs. Temperature

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Figure 28. Transresistance vs. Temperature


Figure 31. Output Resistance vs. Frequency


Figure 29. Noise vs. Frequency


Figure 30. CMRR vs. Temperature

Figure 32. $-3 d B$ Bandwidth vs. Frequency, $G=-1$


Figure 33. PSRR vs. Temperature

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Figure 34. CMRR vs. Frequency


Figure 35. $-3 d B$ Bandwidth vs. Frequency, $G=-2$


Figure 37. PSRR vs. Frequency


Figure 38. 2 V Step Response, $G=-1$


Figure 36. 100 mV Step Response, $G=-1$


Figure 39. Input Offset Voltage Distribution

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## THEORY OF OPERATION

A very simple analysis can put the operation of the AD8002, a current feedback amplifier, in familiar terms. Being a current feedback amplifier, the AD8002's open-loop behavior is expressed as transimpedance, $\Delta \mathrm{V}_{\mathrm{O}} / \Delta \mathrm{I}_{\mathrm{IN}}$, or $\mathrm{T}_{\mathrm{Z}}$. The open loop transimpedance behaves just as the open loop voltage gain of a voltage feedback amplifier, that is, it has a large dc value and decreases at roughly $6 \mathrm{~dB} /$ octave in frequency.
Since the $R_{I N}$ is proportional to $1 / g_{M}$, the equivalent voltage gain is just $T_{Z} \times g_{M}$, where the $g_{M}$ in question is the transconductance of the input stage. This results in a low open loop input impedance at the inverting input, a now familiar result. Using this amplifier as a follower with gain, Figure 40, basic analysis yields the following result.

$$
\frac{V_{O}}{V_{I N}}=G \times \frac{T_{\mathrm{Z}}(S)}{T_{\mathrm{Z}}(S)+G \times R_{I N}+R_{1}}
$$

$$
G=1+\frac{R_{1}}{R_{2}} \quad R_{I N}=1 / g_{M} \approx 50 \Omega
$$

Figure 40.
Recognizing that $G \times R_{I N} \ll R_{1}$ for low gains, it can be seen to the first order that bandwidth for this amplifier is independent of gain (G). This simple analysis in conjunction with Figure 41 in fact can predict the behavior of the AD8002 over a wide range of conditions.


Figure 41. Frequency Response, $G=+2$

Considering that additional poles contribute excess phase at high frequencies there is a minimum feedback resistance below which peaking or oscillation may result. This fact is used to determine the optimum feedback resistance, $\mathrm{R}_{\mathrm{F}}$. In practice parasitic capacitance at Pin 2 will also add phase in the feedback loop, so picking an optimum value for $\mathrm{R}_{\mathrm{F}}$ can be difficult. Figure 42 illustrates this problem. Here the fine scale ( $0.1 \mathrm{~dB} /$ div ) flatness is plotted vs. feedback resistance.
Achieving and maintaining gain flatness of better than 0.1 dB at frequencies above 10 MHz requires careful consideration of several issues.


Figure 42. 0.1 dB Flatness vs. Frequency, $G=+2$
Choice of Feedback and Gain Resistors
Because of the above mentioned relationship between the bandwidth and the feedback resistor, the fine scale gain flatness will, to some extent, vary with feedback resistance. It, therefore, is recommended that once optimum resistor values have been determined, $1 \%$ tolerance values should be used if it is desired to maintain flatness over a wide range of production lots. In addition, resistors of different construction have different associated parasitic capacitance and inductance. Surface mount resistors were used for the bulk of the characterization for this data sheet. It is not recommended that leaded components be used with the AD8002.

## Printed Circuit Board Layout Considerations

As to be expected for a wideband amplifier, PC board parasitics can affect the overall closed loop performance. Of concern are stray capacitances at the output and the inverting input nodes. If a ground plane is to be used on the same side of the board as the signal traces, a space ( 5 mm min ) should be left around the signal lines to minimize coupling. Additionally, signal lines connecting the feedback and gain resistors should be short enough so that their associated inductance does not cause high frequency gain errors. Line lengths on the order of less than 5 mm are recommended. If long runs of coaxial cable are being driven, dispersion and loss must be considered.

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## Power Supply Bypassing

Adequate power supply bypassing can be critical when optimizing the performance of a high frequency circuit. Inductance in the power supply leads can form resonant circuits that produce peaking in the amplifier's response. In addition, if large current transients must be delivered to the load, then bypass capacitors (typically greater than $1 \mu \mathrm{~F}$ ) will be required to provide the best settling time and lowest distortion. A parallel combination at least $4.7 \mu \mathrm{~F}$ and between $0.1 \mu \mathrm{~F}$ and $0.01 \mu \mathrm{~F}$ is recommended. Some brands of electrolyic capacitors will require a small series damping resistor $\approx 4.7 \Omega$ for optimum results.

## DC Errors and Noise

There are three major noise and offset terms to consider in a current feedback amplifier. For offset errors refer to the equation below. For noise error the terms are root-sum-squared to give a net output error. In the circuit below (Figure 43) they are input offset $\left(\mathrm{V}_{\mathrm{IO}}\right)$ which appears at the output multiplied by the noise gain of the circuit ( $1+\mathrm{R}_{\mathrm{F}} / \mathrm{R}_{\mathrm{I}}$ ), Noninverting input current ( $\mathrm{I}_{\mathrm{BN}} \times \mathrm{R}_{\mathrm{N}}$ ) also multiplied by the noise gain, and the inverting input current, which when divided between $R_{F}$ and $R_{I}$ and subsequently multiplied by the noise gain always appears at the output as $\mathrm{I}_{\mathrm{BN}} \times \mathrm{R}_{\mathrm{F}}$. The input voltage noise of the AD8002 is a low $2 \mathrm{nV} / \sqrt{\mathrm{Hz}}$. At low gains though the inverting input current noise times $\mathrm{R}_{\mathrm{F}}$ is the dominant noise source. Careful layout and device matching contribute to better offset and drift specifications for the AD8002 compared to many other current feedback amplifiers. The typical performance curves in conjunction with the equations below can be used to predict the performance of the AD8002 in any application.

$$
V_{O U T}=V_{I O} \times\left(1+\frac{R_{F}}{R_{I}}\right) \pm I_{B N} \times R_{N} \times\left(1+\frac{R_{F}}{R_{I}}\right) \pm I_{B I} \times R_{F}
$$



Figure 43. Output Offset Voltage

## Driving Capacitive Loads

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worth noting that the frequency response of the circuit when driving large capacitive loads will be dominated by the passive roll-off of $\mathrm{R}_{\text {SERIES }}$ and $\mathrm{C}_{\mathrm{L}}$


Figure 45. Recommended $R_{\text {SERIES }}$ vs. Capacitive Load

## Communications

Distortion is a key specification in communications applications. Intermodulation distortion (IMD) is a measure of the ability of an amplifier to pass complex signals without the generation of spurious harmonics. The third order products are usually the most problematic since several of them fall near the fundamentals and do not lend themselves to filtering. Theory predicts that the third order harmonic distortion components increase in power at three times the rate of the fundamental tones. The specification of third order intercept as the virtual point where fundamental and harmonic power are equal is one standard measure of distortion performance. Op amps used in closedloop applications do not always obey this simple theory. At a gain of two, the AD8002 has performance summarized in Figure 46 . Here the worst third order products are plotted vs. input power. The third order intercept of the AD8002 is +33 dBm at 10 MHz .


Figuire 46. Third Order $I M D ; F_{1}=10 \mathrm{MHz}, F_{2}=12 \mathrm{MHz}$

Figure 44. Driving Capacitive Loads
shows the optimum value for $\mathrm{R}_{\text {SERIES }}$ vs. capacitive load. It is
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## Operation as a Video Line Driver

The AD8002 has been designed to offer outstanding performance as a video line driver. The important specifications of differential gain ( $0.01 \%$ ) and differential phase $\left(0.025^{\circ}\right)$ meet the most exacting HDTV demands for driving one video load with each amplifier. The AD8002 also drives up to four back terminated loads, as shown in Figure 47, with equally impressive performance. Another important consideration is isolation between loads in a multiple load application. The AD8002 has more than 40 dB of isolation at 5 MHz when driving two $75 \Omega$ back terminated loads.

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The AD8002 is well suited for driving high speed analog-todigital converters such as the AD9058. The AD9058 is a dual 8 -bit 50 Msps ADC. In the circuit below the AD8002 is shown driving the inputs of the AD9058 which are configured for 0 V to +2 V ranges. Bipolar input signals are buffered, amplified $(-2 \times)$, and offset (by +1.0 V ) into the proper input range of the ADC. Using the AD9058's internal +2 V reference connected to both ADCs as shown in Figure 48 reduces the number of external components required to create a complete data acquisition system. The $20 \Omega$ resistors in series with ADC inputs are used to help the AD8002s drive the 10 pF ADC input capacitance. The two AD8002s only add 100 mW to the power consumption while not limiting the performance of the circuit.


Figure 47. Video Line Driver

Figure 48. AD8002 Driving a Dual A-to-D Converter

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## AD8002

## Layout Considerations

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The PCB should have a ground plane covering all unused portions of the component side of the board to provide a low impedance ground path. The ground plane should be removed from the area near the input pins to reduce stray capacitance.
Chip capacitors should be used for supply bypassing (see Figure 49). One end should be connected to the ground plane and the other within $1 / 8 \mathrm{in}$. of each power pin. An additional large ( $4.7 \mu \mathrm{~F}-10 \mu \mathrm{~F}$ ) tantalum electrolytic capacitor should be connected in parallel, but not necessarily so close, to supply current for fast, large-signal changes at the output.
The feedback resistor should be.located close to the inverting input pin in order to keep the stray capacitance at this node to a minimum. Capacitance variations of less than 1 pF at the inverting input will significantly affect high speed performance.

Stripline design techniques should be used for long signal traces (greater than about 1 in .). These should be designed with a characteristic impedance of $50 \Omega$ or $75 \Omega$ and be properly terminated at each end.


Inverting Configuration


Supply Bypassing


Noninverting Configuration
Figure 49. Inverting and Noninverting Configurations

Table I. Recommended Component Values

|  | $\begin{gathered} \text { AD8002AN (DIP) } \\ \text { Gain } \\ \hline \end{gathered}$ |  |  |  |  | AD8002AR (SOIC) Gain |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Component | -1 | +1* | +2 | +10 | +100 | -1 | +1** | +2 | +10 | +100 |
| $\mathrm{R}_{\mathrm{F}}$ | $576 \Omega$ | $1210 \Omega$ | $750 \Omega$ | 499 ת | $1000 \Omega$ | $549 \Omega$ | $1210 \Omega$ | $681 \Omega$ | 499 ת | $1000 \Omega$ |
| $\mathrm{R}_{\mathrm{G}}$ | $576 \Omega$ | - | $750 \Omega$ | 54.9 ת | $10 \Omega$ | 549 ת | - | $681 \Omega$ | $54.9 \Omega$ | $10 \Omega$ |
| $\mathrm{R}_{\mathrm{O}}$ (Nominal) | $49.9 \Omega$ | $49.9 \Omega$ | 49.9 ת | 49.9 ת | $49.9 \Omega$ | $49.9 \Omega$ | 49.9 ת | 49.9 ת | $49.9 \Omega$ | $49.9 \Omega$ |
| $\mathrm{R}_{\text {S }}$ | $0 \Omega$ | - | - | - | - | $0 \Omega$ | - | - | - | - |
| $\mathrm{R}_{\mathrm{T}}$ (Nominal) | $54.9 \Omega$ | $49.9 \Omega$ | 49.9 ת | 49.9 ת | $49.9 \Omega$ | $54.9 \Omega$ | $49.9 \Omega$ | 49.9 ת | $49.9 \Omega$ | $49.9 \Omega$ |
| Small Signal BW (MHz) | 355 | 580 | 650 | 170 | 17 | 410 | 580 | 440 | 170 | 17 |
| 0.1 dB Flatness (MHz) | 135 | 35 | 50 | 24 | 3 | 100 | 35 | 120 | 24 | 3 |

NOTES
${ }^{*} 100 \Omega$ resistor used in series with the noninverting input.
** $90.9 \Omega$ resistor used in series with the noninverting input.

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Quad $3000 \mathrm{~V} / \mu \mathrm{s}, 35 \mathrm{~mW}$ Current Feedback Amplifier

FEATURES
High Speed
$400 \mathrm{MHz} \mathrm{-3} \mathrm{~dB}$ Bandwidth ( $\mathbf{G}=+1$ )
3000 V/ $\mu$ s Slew Rate
10 ns Settling Time to $0.1 \%$
0.9 ns Rise Time for 2 V Step

## Low Power

3.5 mA/Amp Power Supply Current ( $35 \mathrm{~mW} /$ Amp)

Single Supply Operation
Fully Specified for +5 V Supply
Great Video Specifications ( $\mathrm{R}_{\mathrm{L}}=150 \Omega, \mathrm{G}=+2$ )
Gain Flatness 0.1 dB to 30 MHz
0.05\% Differential Gain Error
$0.05^{\circ}$ Differential Phase Error
Low Distortion
-65 dBc THD at 10 MHz
$33 \mathbf{d B m}$ Third Order Intercept, $\mathrm{f}=\mathbf{1 0} \mathbf{~ M H z}$
$\mathbf{- 6 5} \mathrm{dB}$ SFDR, $\mathrm{f}=\mathbf{2 0} \mathbf{~ M H z}$
High Output Current of 50 mA
Available in a Small 14-Pin PDIP and SOIC
APPLICATIONS
Image Scanners
Active Filters
Video Switchers
Special Effects

FUNCTIONAL BLOCK DIAGRAM


## PRODUCT DESCRIPTION

The AD8004 is a quad, low power, high speed amplifier designed to operate on +5 V or $\pm 5 \mathrm{~V}$ supplies. It utilizes a current feedback architecture and features high slew rate of $3000 \mathrm{~V} / \mathrm{hs}$ making the AD8004 ideal for handling large amplitude pulses. Additionally, the AD8004 provides gain flatness of 0.1 dB to 30 MHz while offering differential gain and phase error of $0.05 \%$ and $0.05^{\circ}$. This makes the AD8004 suitable for professional video electronics such as cameras and video switchers.
The AD8004 offers low power of $3.5 \mathrm{~mA} /$ amplifier and can run on a single +5 V or +12 V power supply, while being capable of delivering up to 50 mA of load current. All this is offered in a small 14-pin DIP or 14-pin SOIC package. These features make this amplifier ideal for portable and battery powered applications where size and power is critical.
The outstanding bandwidth of 400 MHz along with $3000 \mathrm{~V} / \mu \mathrm{s}$ of slew rate make the AD8004 useful in many general purpose high speed applications where dual power supplies of up to $\pm 6 \mathrm{~V}$ and single supplies from 5 V to 12 V are needed. The AD8004 is available in the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.

[^159]This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

AD800A-SPEGFIGATIONS $\left(@ T_{A}=+25^{\circ} \mathrm{C}, \mathrm{V}_{S}= \pm 5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=100 \Omega, \mathrm{R}_{F}=500 \Omega\right.$ unless otherwise noted)

| Parameter | Conditions | AD8004A |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max |  |
| DYNAMIC PERFORMANCE |  |  |  |  |  |
| -3 dB Bandwidth | $\mathrm{G}=+2,<0.1 \mathrm{~dB}$ Peaking |  | 250 |  | MHz |
|  | $\mathrm{G}=+1$ |  | 400 |  | MHz |
| Bandwidth for 0.1 dB Flatness | $\mathrm{G}=+2$ |  | 30 |  | MHz |
| Slew Rate | $\mathrm{G}=+2$ |  | 3000 |  | $\mathrm{V} / \mathrm{L}^{\text {s }}$ |
|  | $\mathrm{G}=-1$ |  | TBD |  | $\mathrm{V} / \mu \mathrm{s}$ |
| Settling Time to 0.1\% | $\mathrm{G}=-1, \mathrm{~V}_{\mathrm{O}}=2 \mathrm{~V}$ Step |  | 10 |  | ns |
| Rise \& Fall Time | $\mathrm{G}=1, \mathrm{~V}_{\mathrm{O}}=2 \mathrm{~V}$ Step |  | 0.9 |  | ns |
| NOISE/HARMONIC PERFORMANCE |  |  |  |  |  |
| Total Harmonic Distortion | $\mathrm{f}_{\mathrm{C}}=10 \mathrm{MHz}, \mathrm{V}_{\mathrm{O}}=2 \mathrm{~V} p-\mathrm{p}$ |  | -65 |  | dBc |
| Crosstalk | $\mathrm{f}=5 \mathrm{MHz}$ |  | -60 |  |  |
| Input Voltage Noise | $\mathrm{f}=10 \mathrm{kHz}$ |  | 3.0 |  | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| Input Current Noise | $\begin{array}{r} \mathrm{f}=10 \mathrm{kHz}, \\ -\mathrm{In} \\ -\mathrm{In} \end{array}$ |  | 2.0 |  | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
|  |  |  | 18 |  | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
| Differential Gain Error | NTSC, $\mathrm{G}=+2, \mathrm{R}_{\mathrm{L}}=150 \Omega$ |  | 0.05 |  | \% |
| Differential Phase Error | NTSC, $\mathrm{G}=+2, \mathrm{R}_{\mathrm{L}}=150 \Omega$ |  | 0.05 |  | Degree |
| Third Order Intercept | $\mathrm{f}=10 \mathrm{MHz}$ |  | 33 |  | dBm |
| SFDR | $\mathrm{f}=20 \mathrm{MHz}$ |  |  |  | dB |
| 1 dB Gain Compression | $\mathrm{f}=10 \mathrm{MHz}$ | 4 |  |  | dBm |
| DC PERFORMANCE |  |  |  |  |  |
| Input Offset Voltage | $\mathrm{T}_{\mathrm{MIN}}-\mathrm{T}_{\mathrm{MAX}}$ | (2) |  | 15 | mV |
|  |  | $\leqslant$ | TBD | TBD | mV |
| Offset Drift |  | + | 30 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| -Input Bias Current |  |  | 5.0 | 25 | $\pm \mu \mathrm{A}$ |
| +Input Bias Current | $\mathrm{T}_{\mathrm{MIN}} \mathrm{T}_{\mathrm{MAX}}$$\mathrm{V}_{\mathrm{O}}= \pm 2.5 \mathrm{~V}$ | , | 5.0 | TBD 15 | $\begin{aligned} & \pm \mu \mathrm{A} \\ & \pm \mu \mathrm{A} \end{aligned}$ |
|  |  |  |  | TBD | $\pm \mu \mathrm{A}$ |
| Open-Loop Transresistance |  |  | 300 |  | $\mathrm{k} \Omega$ |
|  | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ |  | TBD |  | $\mathrm{k} \Omega$ |
| INPUT CHARACTERISTICS |  |  |  |  |  |
| Input Resistance | +Input <br> -Input <br> +Input | 2 |  |  | $\mathrm{M} \Omega$ |
|  |  |  | 50 |  | $\Omega$ |
| Input Capacitance |  |  | 1.5 |  | pF |
| Input Common-Mode Voltage Range | +Input |  | 3.2 |  | $\pm \mathrm{V}$ |
| Common-Mode Rejection Ratio |  |  |  |  |  |
| Offset Voltage | $\mathrm{V}_{\mathrm{CM}}= \pm 2.5 \mathrm{~V}$ | 50 | 54 |  | dB |
| -Input Current | $\mathrm{V}_{\mathrm{CM}}= \pm 2.5 \mathrm{~V}, \mathrm{~T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ |  | TBD | TBD | $\mu \mathrm{A} / \mathrm{V}$ |
| +Input Current | $\mathrm{V}_{\mathrm{CM}}= \pm 2.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{MIN}} \mathrm{T}^{\text {MAX }}$ |  | TBD | TBD | $\mu \mathrm{A} / \mathrm{V}$ |
| OUTPUT CHARACTERISTICS |  |  |  |  |  |
| Output Voltage Swing | $\mathrm{R}_{\mathrm{L}}=150 \Omega$ | 1.1 to 3.9 |  |  | $\pm \mathrm{V}$ |
| Output Current |  | 50 |  |  | mA |
| Short Circuit Current |  | TBD |  |  | mA |
| POWER SUPPLY |  |  |  |  |  |
| Operating Range |  | $\pm 2.5$ |  | $\pm 6.0$ | V |
| Quiescent Current | $\mathrm{T}_{\text {MIN }-} \mathrm{T}_{\text {MAX }}$ |  | 3.5 |  | mA |
| Power Supply Rejection Ratio | $\mathrm{V}_{\mathrm{S}}= \pm 1.75 \mathrm{~V}$ to $\pm 6 \mathrm{~V}$ |  | 60 |  | dB |
| -Input Current | $\mathrm{T}_{\text {MIN- }} \mathrm{T}_{\text {MAX }}$ |  | TBD | TBD | $\mu \mathrm{A} / \mathrm{V}$ |
| +Input Current | $\mathrm{T}_{\text {MIN }-} \mathrm{T}_{\text {MAX }}$ |  | TBD | TBD | $\mu \mathrm{A} / \mathrm{V}$ |

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$\left(@ T_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{S}}=+5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=100 \Omega, \mathrm{R}_{\mathrm{F}}=500 \Omega\right.$ unless otherwise noted)

| Parameter | Conditions | Min | $\begin{aligned} & \text { D8004A } \\ & \text { Typ } \end{aligned}$ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DYNAMIC PERFORMANCE <br> -3 dB Bandwidth <br> Bandwidth for 0.1 dB Flatness Slew Rate <br> Settling Time to $0.1 \%$ Rise \& Fall Time | $\begin{aligned} & G=+2,<0.1 \mathrm{~dB} \text { Peaking } \\ & G=+1 \\ & G=+2 \\ & G=+2 \\ & G=-1 \\ & G=-1, V_{O}=2 \mathrm{~V} \text { Step } \\ & G=1, V_{O}=2 \mathrm{~V} \text { Step } \end{aligned}$ |  | $\begin{aligned} & 250 \\ & 400 \\ & 30 \\ & 3000 \\ & \text { TBD } \\ & 10 \\ & 0.9 \end{aligned}$ |  | MHz <br> MHz <br> MHz <br> $\mathrm{V} / \mu \mathrm{s}$ <br> $\mathrm{V} / \mathrm{\mu s}$ <br> ns <br> ns |
| NOISE/HARMONIC PERFORMANCE <br> Total Harmonic Distortion Crosstalk Input Voltage Noise Input Current Noise <br> Differential Gain Error Differential Phase Error Third Order Intercept SFDR <br> 1 dB Gain Compression | $\begin{aligned} & \mathrm{f}_{\mathrm{C}}=10 \mathrm{MHz}, \mathrm{~V}_{\mathrm{O}}=2 \mathrm{Vp}-\mathrm{p} \\ & \mathrm{f}=5 \mathrm{MHz} \\ & \mathrm{f}=10 \mathrm{kHz} \\ & \mathrm{f}=10 \mathrm{kHz},+\mathrm{In} \\ & \text { NTSC, } \quad-\mathrm{In}=+2, \mathrm{R}_{\mathrm{L}}=150 \Omega \\ & \mathrm{NTSC}, \mathrm{G}=+2, \mathrm{R}_{\mathrm{L}}=150 \Omega \\ & \mathrm{f}=10 \mathrm{MHz} \\ & \mathrm{f}=20 \mathrm{MHz} \\ & \mathrm{f}=10 \mathrm{MHz} \end{aligned}$ | $10$ | $\begin{aligned} & -65 \\ & -60 \\ & 3.0 \\ & 2.0 \\ & 18 \\ & 0.07 \\ & 0.07 \\ & 33 \\ & -65 \\ & 14 \end{aligned}$ |  | dBc <br> dB <br> $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ <br> $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ <br> $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ <br> \% <br> Degree <br> dBm <br> dB <br> dBm |
| DC PERFORMANCE <br> Input Offset Voltage <br> Offset Drift -Input Bias Current +Input Bias Current Open Loop Transresistance | $\mathrm{T}_{\text {MIN }} \mathrm{T}_{\mathrm{MAX}}$ <br> $\mathrm{T}_{\text {MII }}-\mathrm{T}_{\text {MAX }}$ <br> $\mathrm{V}_{\mathrm{O}}=+1 \mathrm{~V}$ to +3.9 V <br> $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ | $3$ | $\begin{aligned} & 5.0 \\ & \text { TBD } \\ & 30 \\ & 5.0 \\ & 5.0 \\ & \\ & 300 \\ & \text { TBD } \end{aligned}$ | $\begin{aligned} & 15 \\ & \text { TBD } \\ & 25 \\ & \text { TBD } \\ & 15 \\ & \text { TBD } \end{aligned}$ | mV <br> mV <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ <br> $\pm \mu \mathrm{A}$ <br> $\pm \mu \mathrm{A}$ <br> $\pm \mu \mathrm{A}$ <br> $\pm \mu \mathrm{A}$ <br> $\mathrm{k} \Omega$ <br> $\mathrm{k} \Omega$ |
| INPUT CHARACTERISTICS <br> Input Resistance <br> Input Capacitance <br> Input Common-Mode Voltage Range <br> Common-Mode Rejection Ratio Offset Voltage -Input Current +Input Current | $\begin{aligned} & \text { +Input } \\ & \text {-Input } \\ & \text { +Input } \\ & \\ & \mathrm{V}_{\mathrm{CM}}=+1 \mathrm{~V} \text { to }+3 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CM}}=+1 \mathrm{~V} \text { to }+3 \mathrm{~V}, \mathrm{~T}_{\mathrm{MII}}-\mathrm{T}_{\mathrm{MAX}} \\ & \mathrm{~V}_{\mathrm{CM}}=+1 \mathrm{~V} \text { to }+3 \mathrm{~V}, \mathrm{~T}_{\mathrm{MIN}}-\mathrm{T}_{\mathrm{MAX}} \\ & \hline \end{aligned}$ | 50 | $\begin{aligned} & 2 \\ & 50 \\ & 1.5 \\ & 3.2 \\ & \\ & 54 \\ & \text { TBD } \\ & \text { TBD } \\ & \hline \end{aligned}$ | TBD <br> TBD | $\mathrm{M} \Omega$ <br> $\Omega$ <br> $\stackrel{\mathrm{pF}}{\mathrm{V}}$ <br> dB <br> $\mu \mathrm{A} / \mathrm{V}$ <br> $\mu \mathrm{A} / \mathrm{V}$ |
| OUTPUT CHARACTERISTICS <br> Output Voltage Swing <br> Output Current <br> Short Circuit Current | $\mathrm{R}_{\mathrm{C}}=150 \Omega$ |  | $\begin{aligned} & 1.1 \text { to } 3.9 \\ & 50 \\ & \text { TBD } \end{aligned}$ |  | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~mA} \\ & \mathrm{~mA} \end{aligned}$ |
| POWER SUPPLY <br> Operating Range Quiescent Current Power Supply Rejection Ratio -Input Current +Input Current | $\begin{aligned} & \mathrm{T}_{\text {MIN }-} \mathrm{T}_{\text {MAX }} \\ & \mathrm{V}_{\mathrm{S}}=+3.5 \mathrm{~V} \text { to }+12 \mathrm{~V} \\ & \mathrm{~T}_{\text {MIN }} \mathrm{T}_{\mathrm{MAX}} \\ & \mathrm{~T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }} \end{aligned}$ | 0, +5 | 3.5 <br> 60 <br> TBD <br> TBD | $+12$ <br> TBD <br> TBD | V <br> mA <br> dB <br> $\mu \mathrm{A} / \mathrm{V}$ <br> $\mu \mathrm{A} / \mathrm{V}$ |

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#### Abstract

ABSOLUTE MAXIMUM RATINGS ${ }^{\mathbf{1}}$ Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 12.6 V Internal Power Dissipation ${ }^{2}$ Plastic Package (N) . . . . . . . . . . . . . . . . . . . . . . . . . 6 Watts Small Outline Package (R) . . . . . . . . . . . . . . . . . . . . 1.0 Watts Input Voltage (Common Mode) . . . . . . . . . . . . . . . . . . . $\pm \mathrm{V}_{\mathrm{S}}$ Differential Input Voltage . . . . . . . . . . . . . . . . . . . . . $\pm 1.2 \mathrm{~V}$ Output Short Circuit Duration


. Observe Power Derating Curves
Storage Temperature Range (N, R) . . . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ Operating Temperature Range (A Grade) $\ldots . .40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ Lead Temperature Range (Soldering 10 sec ) $\qquad$ $+300^{\circ} \mathrm{C}$

## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ Specification is for device in free air:
14-Pin plastic DIP package: $\theta_{\mathrm{JA}}=75^{\circ} \mathrm{C} / \mathrm{W}$
14-pin SOIC package: $\theta_{\mathrm{JA}}=120^{\circ} \mathrm{C} / \mathrm{W}$.

## MAXIMUM POWER DISSIPATION

The maximum power that can be safely dissipated by the AD8004 is limited by the associated rise in junction temperature. The maximum safe junction temperature for plastic encapsulated devices is determined by the glass transition temperature of the plastic, approximately $+150^{\circ} \mathrm{C}$. Exceeding this limit temporarily may cause a shift in parametric performance due to a change in the stresses exerted on the die by the package. Exceeding a junction temperature of $+175^{\circ} \mathrm{C}$ for an extended period can result in device failure.
While the AD8004 is internally short circuit protected, this may not be sufficient to guarantee that the maximum junction temperature $\left(+150^{\circ} \mathrm{C}\right)$ is not exceeded under all conditions. To ensure proper operation, it is necessary to observe the maximum power derating curve below.

## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD8004AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 14-Pin Plastic DIP | N-14 |
| AD8004AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 14-Pin Plastic SOIC | R-14 |

*For outline information see Package Information section.


Figure 2. Maximum Power Dissipation vs. Ambient Temperature

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD8004 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


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Low Distortion, Wide Bandwidth Voltage Feedback Clamp Amps

## FEATURES

Superb Clamping Characteristics
<25 mV Clamp Accuracy
3 ns Overdrive Recovery
Minimized Nonlinear Clamping Region
Wide Bandwidth AD8036 AD8037
Small Signal $\quad 350 \mathrm{MHz} \quad 240 \mathrm{MHz}$
Large Signal (4 V p-p) $200 \mathrm{MHz} \quad 150 \mathrm{MHz}$
Good DC Characteristics
2 mV Offset
$10 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ Drift
Ultralow Distortion, Low Noise
-90 dBc typ @ 5 MHz
-64 dBc typ @ 20 MHz
$5.6 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ Spectral Noise Density
High Speed
Slew Rate 1600 V/ $\mu \mathrm{s}$
Settling 11 ns to 0.1\%, 16 ns to 0.01\%
$\pm 3$ V to $\pm 5$ V Supply Operation

## APPLICATIONS

ADC Buffer
IF/RF Signal Processing
High Quality Imaging
Broadcast Video Systems
Video Amplifier

## PRODUCT DESCRIPTION

The AD8036 and AD8037 are very high speed and wide bandwidth input clamping amplifiers. The AD8036 is unity-gain stable. The AD8037 is stable at a gain of two. Utilizing proprietary input clamping architecture, the AD8036 and AD8037 offer unparalleled clamp amp performance. Also, utilizing a voltage feedback architecture, their exceptional settling time, bandwidth, and low distortion performance meet the requirements of many applications that previously depended on current feedback amplifiers. Their classical op amp structure works much more predictably in many designs. This product can be used as a classical op amp or a clamp amp where a high and low output voltage is specified.

A proprietary design architecture has produced an amplifier that combines many of the best characteristics of both current feedback and voltage feedback amplifiers. The AD8036 and AD8037 exhibit exceptionally fast and accurate pulse response ( 16 ns to $0.01 \%$ ) as well as extremely wide small signal and large signal bandwidth and ultralow distortion. The AD8036 achieves -68 dBc at 20 MHz with 350 MHz small signal and 200 MHz large signal bandwidths. The AD8036 and AD8037's clamp accuracy is 25 mV or less and it recovers from overdrive within 2 ns .

This is a preliminary data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

FUNCTIONAL BLOCK DIAGRAM<br>8-Pin Plastic Mini-DIP (N), Cerdip (Q), and SO (R) Packages



These characteristics position the AD8036/AD8037 ideally for driving as well as buffering flash and high resolution ADCs. Additionally, nonlinear functions with high speed and wide bandwidth are made possible by the balanced high impedance inputs of the voltage feedback architecture.
The AD8036 is offered in industrial $\left(-40^{\circ} \mathrm{C}\right.$ to $\left.+85^{\circ} \mathrm{C}\right)$ and military $\left(-55^{\circ} \mathrm{C}\right.$ to $\left.+125^{\circ} \mathrm{C}\right)$ temperature ranges and the AD 8037 in industrial. Industrial versions are available in plastic DIP and

SOIC; MIL versions are packaged in cerdip.


Figure 1. Clamp Accuracy

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AD8036/AD8037-SPECIFICATIONS ELEGTRICAL CHARACTERIST|CS Unless otherwise noted, $\pm V_{S}= \pm 5 V^{\prime} R_{L 0 A D}=100 \Omega ; A_{V}=1$ (AD8036); $A_{V}=2$ (AD8037)

| Parameter | Conditions | Temp. | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DYNAMIC PERFORMANCEBandwidth ( $-3 \mathrm{dB)}$ |  |  |  |  |  |  |
|  |  |  |  |  |  |  |
| Small Signal AD8036 | $\mathrm{V}_{\text {OUT }} \leq 0.4 \mathrm{~V}$ p-p | Full |  | 350 |  | MHz |
| AD8037 | $\mathrm{V}_{\text {OUT }} \leq 0.4 \mathrm{~V}$ p-p | Full |  | 240 |  | MHz |
| Large Signal AD8036 | $\mathrm{V}_{\text {OUT }}=4 \mathrm{~V}$ p-p | Full |  | 200 |  | MHz |
| AD8037 | $\mathrm{V}_{\text {OUT }}=4 \mathrm{~V}$ p-p | Full |  | 150 |  | MHz |
| Amplitude of Peaking | Full Spectrum | Full |  | 0.1 |  | dB |
| Flatness | 40 MHz | Full |  | 0.1 |  | dB |
| Common-Mode Rejection Ratio | @ 20 MHz | $+25^{\circ} \mathrm{C}$ |  | +28 |  | dB |
| Slew Rate | $\mathrm{V}_{\text {OUT }}=4 \mathrm{~V}$ Step | Full |  | 1600 |  | $\mathrm{V} / \mu \mathrm{s}$ |
| Rise/Fall Time | $\mathrm{V}_{\text {Out }}=0.5 \mathrm{~V}$ Step | $+25^{\circ} \mathrm{C}$ |  | 1.5 |  | ns |
|  | $\mathrm{V}_{\text {OUT }}=4 \mathrm{~V}$ Step | Full |  | 3.6 |  | ns |
| Overshoot | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ Step | Full |  | 0 |  | \% |
| Settling Time $\quad$ U |  |  |  |  |  |  |
| To 0.1\% | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ Step | $+25^{\circ} \mathrm{C}$ |  | 11 |  | ns |
| To 0.01\% | $\mathrm{V}_{\text {Out }}=2 \mathrm{~V}$ Step | Full |  | 16 |  | ns |
| To 0.1\% | $\mathrm{V}_{\text {OUT }}=4 \mathrm{~V}$ Step | $+25^{\circ} \mathrm{C}$ |  |  |  | ns |
| To 0.02\% | $\mathrm{V}_{\text {OUT }}=4 \mathrm{~V}$ Step | $+25^{\circ} \mathrm{C}$ |  |  |  | ns |
| CLAMP PERFORMANCE |  |  |  |  |  |  |
| Clamp Voltage Range | $\mathrm{V}_{\mathrm{H}}$ or $\mathrm{V}_{\mathrm{L}}$ | Full | $\pm 3.3$ | $\pm 3.5$ |  | V |
| Clamp Accuracy | $2 \times$ Overdrive | Full | + | $\pm 25$ | $\pm 50$ | mV |
| Clamp Nonlinearity Range ${ }^{1}$ | $2 \times$ Overdrive | Full |  |  |  |  |
| Bias Current ( $\mathrm{V}_{\mathrm{H}}$ or $\mathrm{V}_{\mathrm{L}}$ ) | E- | $+25^{\circ} \mathrm{C}$ |  | 50 | 100 | $\mu \mathrm{A}$ |
| Clamp Input Bandwidth ( -3 dB ) | $\mathrm{V}_{\mathrm{H}}$ or $\mathrm{V}_{\mathrm{L}}=2 \mathrm{Vp}-\mathrm{p}$ | Full | 100 | 250 | : | MHz |
| Clamp Overshoot | $2 \times$ Overdrive | $+25^{\circ} \mathrm{C}$ |  | 4 | 5 | \% |
| Overdrive Recovery | $2 \times$ Overdrive | $+25^{\circ} \mathrm{C}$ |  | 1 | 10 | ns |
| HARMONIC/NOISE PERFORMANCE |  |  |  |  |  |  |
| 2nd Harmonic Distortion |  |  |  |  |  |  |
| AD8036 | 2 V p-p; 20 MHz | Full |  | -68 |  | dBc |
| AD8037 | 2 V -p; 20 MHz | Full |  | -60 |  | dBc |
| 3rd Harmonic Distortion |  |  |  |  |  |  |
| AD8036 | 2 V p-p; 20 MHz | Full |  | -77 |  | dBc |
| AD8037 | 2 V p-p; 20 MHz | Full |  | -70 |  | dBc |
| 3rd Order Intercept | 25 MHz | Full |  | +40 |  | dBm |
| Spectral Input Noise Voltage | 1 MHz to 200 MHz | $+25^{\circ} \mathrm{C}$ |  | 5.6 |  | $\mathrm{nV} / \sqrt{\overline{\mathrm{Hz}}}$ |
| Spectral Input Noise Current | 1 MHz to 200 MHz | $+25^{\circ} \mathrm{C}$ |  | 3.6 |  | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
| Average Equivalent Integrated |  |  |  |  |  |  |
| Input Noise Voltage | 0.1 MHz to 200 MHz | $+25^{\circ} \mathrm{C}$ |  | 80 |  | $\mu \mathrm{V}$ rms |
| Differential Gain (4.3 MHz) | $\mathrm{R}_{\mathrm{L}}=150 \Omega$ | $+25^{\circ} \mathrm{C}$ |  | 0.01 | 0.05 | \% |
| Differential Phase (4.3 MHz) | $\mathrm{R}_{\mathrm{L}}=150 \Omega$ | $+25^{\circ} \mathrm{C}$ |  | 0.01 | 0.05 | Degrees |
| Phase Nonlinearity | DC to 100 MHz | $+25^{\circ} \mathrm{C}$ |  | 1.1 |  | Degrees |
| DC PERFORMANCE ${ }^{2}$ |  |  |  |  |  |  |
| Input Offset Voltage ${ }^{3}$ |  | $+25^{\circ} \mathrm{C}$ |  | $\pm 2$ |  | mV |
| Offset Voltage Drift |  | Full |  | $\pm 10$ |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Bias Current |  | $+25^{\circ} \mathrm{C}$ |  | 7 |  |  |
| Input Bias Current TC |  | Full |  | 35 |  | $\mathrm{nA} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current |  | $+25^{\circ} \mathrm{C}$ |  | 3 |  | $\mu \mathrm{A}$ |
| Input Offset Current TC |  | Full |  | 2.5 |  | $\mathrm{nA} /{ }^{\circ} \mathrm{C}$ |
| Common-Mode Rejection Ratio | $\Delta \mathrm{V}_{\mathrm{CM}}=1 \mathrm{~V}$ | $+25^{\circ} \mathrm{C}$ |  | 60 |  | dB |
| Open Loop Gain | $\mathrm{V}_{\text {OUT }}= \pm 2 \mathrm{~V}$ p-p | $+25^{\circ} \mathrm{C}$ |  | 56 |  | dB |

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| Parameter | Conditions | Temp. | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT CHARACTERISTICS <br> Input Resistance Input Capacitance Common-Mode Input Range |  | $\begin{aligned} & +25^{\circ} \mathrm{C} \\ & +25^{\circ} \mathrm{C} \\ & \text { Full } \end{aligned}$ |  | $\begin{aligned} & 500 \\ & 1.2 \\ & \pm 3.4 \\ & \hline \end{aligned}$ |  | $\begin{aligned} & \mathrm{k} \Omega \\ & \mathrm{pF} \\ & \mathrm{~V} \end{aligned}$ |
| OUTPUT CHARACTERISTICS <br> Output Voltage Range <br> Output Current <br> Output Resistance |  | Full Full $+25^{\circ} \mathrm{C}$ |  | $\begin{aligned} & \pm 3.4 \\ & 70 \\ & 0.3 \end{aligned}$ |  | V <br> mA <br> $\Omega$ |
| POWER SUPPLY <br> Supply Voltage ( $\pm \mathrm{V}_{\mathrm{S}}$ ) <br> Quiescent Current Power Supply Rejection Ratio |  | Full Full $+25^{\circ} \mathrm{C}$ | 3.0 | $\begin{aligned} & 5.0 \\ & 17 \\ & 66 \\ & \hline \end{aligned}$ | $\begin{aligned} & 5.5 \\ & 20 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~mA} \\ & \mathrm{~dB} \end{aligned}$ |

NOTES
${ }^{1}$ Nonlinearity is defined as signal distortion as the output approaches the clamping levels.
${ }^{2}$ Measured at $\mathrm{A}_{\mathrm{V}}=20$.
${ }^{3}$ Measured with respect to the inverting input.
Specifications subject to change without notice.
ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

Supply Voltages $\left(\mathrm{I}_{\mathrm{S}}\right)$. ............................... $\mathbf{~} 6.5 \mathrm{~V}$
Common-Mode Input Voltage ............................ $\pm \mathrm{V}_{\mathrm{s}}$
Differential Input Voltage ................................. 6 V
Continuous Output Current ${ }^{2}$
90 mA
Operating Temperature Ranges
AN, AR
SQ/883B
B
(C) . . . . . . . . $55^{\circ} \mathrm{C}$ +125 ${ }^{\circ} \mathrm{C}$
(Ceramic) ............ $65^{\circ} \mathrm{C}$, to $+150^{\circ} \mathrm{C}$
Storage Temperature (Plastic) $\ldots \ldots . . . . . .-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Junction Temperature (Ceramic) ${ }^{3} \ldots \ldots \ldots \ldots \ldots .+175^{\circ} \mathrm{C}$
Junction Temperature (Plastic) ${ }^{3}$.................. $+150^{\circ} \mathrm{C}$
Lead Soldering Temperature (1 Minute) ${ }^{4} \ldots \ldots \ldots .+220^{\circ} \mathrm{C}$

NOTES
${ }^{1}$ Absolute maximum ratings are limiting values to be applied individually, and beyond which the seryiceability of the circuit may be impaired. Functional operability is not necessarily implied. Exposure to absolute maximum rating conditions for an extended period of time may affect device reliability.
${ }^{2}$ Output is short-circuit protected to ground, but not to supplies. Continuous short circuit to ground may affect device reliability.
Typical thermal impedances (part soldered onto board; no air flow):
Ceramic DIP: $\theta_{\mathrm{AA}}=110^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=20^{\circ} \mathrm{C} / \mathrm{W}$
Plastic SOIC: $\theta_{\mathrm{JA}}=150^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=30^{\circ} \mathrm{C} / \mathrm{W}$
Plastic DIP: $\theta_{\mathrm{A}}=140^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=30^{\circ} \mathrm{C} / \mathrm{W}$.
${ }^{4}$ Temperature shown is for surface mount devices, mounted by vapor phase soldering. Through-hole devices (ceramic and plastic DIPs) can be soldered at $+300^{\circ} \mathrm{C}$ for 10 seconds.

## ORDERING GUIDE

| Model | Temperature Range | Package Description | Package Option |
| :--- | :--- | :--- | :--- |
| AD8036AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Plastic DIP | $\mathrm{N}-8$ |
| AD8036AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | SOIC | $\mathrm{R}-8$ |
| AD8036SQ $/ 883 \mathrm{~B}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Cerdip | $\mathrm{Q}-8$ |
| AD8036-EB |  | Evaluation Board |  |
| AD8037AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Plastic DIP | $\mathrm{N}-8$ |
| AD8037AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | SOIC | $\mathrm{R}-8$ |

* $\mathrm{N}=$ Plastic DIP; $\mathbf{Q}=$ Cerdip; $\mathrm{R}=$ SOIC (Small Outline Integrated Circuit.) For outline information see Package Information section.


## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although these devices feature proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.


Figure 2. Noninverting Operation

## Clamp Operation

The AD8036/AD8037 have built-in input clamps that can be used to protect sensitive devices connected to the amplifier output. Clamp operation can only be performed in the noninverting configuration. By utilizing input clamps, the maximum linear range is achieved in conjunction with the highest clamp accuracy.
The clamp voltages (high and low) are connected to pins $\mathrm{V}_{\mathrm{HIGH}}$ (input) and $\mathrm{V}_{\text {Low }}$ (input) accordingly. These are high impedance nodes with minimal current drawn. These input clamp voltages multiplied by the amplifier gain sets the limited output swing range. $\mathrm{V}_{\mathrm{H}}$ (output) $=\mathrm{V}_{\mathrm{H}}$ (input) $\times \mathrm{A}_{\mathrm{V}}$ and $\mathrm{V}_{\mathrm{L}}$ (output) $=$ $\mathrm{V}_{\mathrm{L}}$ (input) $\times \mathrm{A}_{\mathrm{V}}$. The chart on the cover page shows the characteristics of the AD8036/AD8037 in clamped operation versus competitors who use output clamping techniques. The improved accuracy and hard clamping characteristics of the AD8036/AD8037 allow clamps to be used in applications where output clamps cannot be used. Also, the recovery from overdrive will be 1 ns typical.
The proprietary input clamp architecture has also been designed to minimize signal distortion as you approach the clamp voltages. This characteristic is fundamental to the signal integrity in the clamp region and allows for maximum useful amplifier range. Figure 3 shows the distortion of the AD8037 as you approach a high clamp voltage value of 1 V versus the competitors.
In addition, the clamp voltage range is only limited by the output voltage range ( $\pm 3.4 \mathrm{~V}$ ), and the clamp voltages can be set to any value between the $\pm 3.4 \mathrm{~V}$ swing. Of course, the clamps can be set beyond the output voltage swing, but then the output will not be limited by the clamp voltages, but by the swing range. Output clamps typically have limited clamp voltage settings and cannot be set to any voltage between $\pm \mathrm{V}_{\mathrm{Cc}}$. For example, it is typical that a low clamp voltage can be set only as high as +2 V , and the high clamp voltage as low as -2 V . This can be a limiting feature in many applications.

The AD8036/AD8037 have been designed with internal ties from the clamp voltage pins to $\pm \mathrm{V}_{\mathrm{CC}}$, and if the clamp pins are left floating, the low clamp voltage $\left(\mathrm{V}_{\mathrm{L}}\right)$ will be set to $-\mathrm{V}_{\mathrm{CC}}$ and the high clamp voltage $\left(\mathrm{V}_{\mathrm{H}}\right)$ will be set to $+\mathrm{V}_{\mathrm{CC}}$. In this configuration, the AD8036/AD8037 will perform as a standard operational amplifier and will not clamp the output.


Figure 3. Distortion Near Clamp Values
Layout Considerations
The specified high speed performance of the AD8036/AD8037 requires careful attention to board layout and component selection. Proper RF design techniques and low-pass parasitic component selection are mandatory.
The PCB should have a ground plane covering all unused portions of the component side of the board to provide a low impedance path. The ground plane should be removed from the area near the input pins to reduce the stray capacitance.
Chip capacitors should be used for the supply bypassing (see Figure 2). One end should be connected to the ground plane and the other within $1 / 8$ inch of each power pin. An additional large ( $0.47 \mu \mathrm{~F}-10 \mu \mathrm{~F})$ tantalum electrolytic capacitor should be connected in parallel, but not necessarily so close, to supply current for fast, large signal changes at the output.
The feedback resistor should be located close to the inverting input pin in order to keep the stray capacitance at this node to a minimum. Capacitance variations of less than 1 pF at the inverting input will significantly affect high speed performance.
Stripline design techniques should be used for long signal traces (greater than about 1 inch). These should be designed with a characteristic impedance of $50 \Omega$ or $75 \Omega$ and be properly terminated at each end.

## Evaluation Board

An evaluation board for the AD8036 is available that has been carefully laid-out and tested to demonstrate that the specified high speed performance of the device can be realized. For ordering information, please refer to the ordering guide.
The layout of the evaluation board can be used as shown or serve as a guide for a board layout.

Table I.

| Component | AD8036AN (DIP) <br> Gain |  |  |  |  | AD8036AR (SOIC) Gain |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | -1 | +1 | +2 | +10 | +100 | -1 | +1 | +2 | +10 | +100 |
| $\mathrm{R}_{\mathrm{F}}$ | $270 \Omega$ | $140 \Omega$ | $270 \Omega$ | $470 \Omega$ | $100 \Omega$ | $320 \Omega$ | $190 \Omega$ | $320 \Omega$ | 470 ת | $100 \Omega$ |
| $\mathrm{R}_{\mathrm{G}}$ | $270 \Omega$ |  | $270 \Omega$ | $51 \Omega$ | $10 \Omega$ | $320 \Omega$ |  | $320 \Omega$ | $51 \Omega$ | $10 \Omega$ |
| $\mathrm{R}_{\mathrm{o}}$ (Nominal) | $49.9 \Omega$ | $49.9 \Omega$ | $49.9 \Omega$ | $49.9 \Omega$ | $49.9 \Omega$ | $100 \Omega$ | $100 \Omega$ | $100 \Omega$ | $49.9 \Omega$ | $49.9 \Omega$ |
| $\mathrm{R}_{\text {S }}$ | $100 \Omega$ | $130 \Omega$ | $100 \Omega$ | $100 \Omega$ | $100 \Omega$ | $150 \Omega$ | $180 \Omega$ | $150 \Omega$ | $100 \Omega$ | $100 \Omega$ |
| $\underline{\mathrm{R}_{\mathrm{T}} \text { (Nominal) }}$ | $49.9 \Omega$ | $49.9 \Omega$ | $49.9 \Omega$ | $49.9 \Omega$ | $49.9 \Omega$ | $100 \Omega$ | $100 \Omega$ | $100 \Omega$ | $49.9 \Omega$ | $49.9 \Omega$ |



Noninverting Configuration
 Boards

## A Diodeless, High Speed, Full-Wave Rectifier

A high speed, full-wave rectifier (or absolute-value amplifier) circuit using high speed, clamping amplifiers is shown in Figure 5. This circuit topology provides both speed and performance enhancements over the traditional diode-based topologies that contain diodes in the amplifier feedback path. These diode-based topologies have performance limitations at both lower signal input levels and higher bandwidths. One limitation is due to the increase in dynamic resistance of the diode that reduces the amount of feedback at lower signal levels. Another limitation is due to the reduction of the amplifier's open-loop gain at higher frequencies which is required to over come the forward-bias voltage drop of the diode. These limitations are most visible at the zero crossings of the input signal when the diodes must change states.
This circuit in Figure 5 consists of three high speed, clamping amplifiers (U1-U3: AD8037) along with $1 \%$ metal-film resistors used for gain control and input bias current compensation. The high speed, clamp accuracy and large signal bandwidth of the AD8037 make this application feasible. They can accurately clamp the input signal within 5 ns to a user defined level. Since the internal clamping circuitry of these amplifiers is located
within their input stages, these amplifiers can clamp only in the noninverting mode. In this circuit, only U 2 is configured as a clamping amplifier while U1 and U3 function as a buffer and difference amplifier, respectively.

The circuit is configured for positive full-wave rectification by configuring U2 as a gain-of-two, positive half-wave rectifier. This is accomplished by setting the positive clamping threshold level (Pin 8 of U2) to the positive supply (hence, outside the input voltage range of the amplifiers input) and the negative clamping threshold level (Pin 5 of U2) to ground. For negative full-wave rectification, U2 must be configured as a gain-of-two, negative half-wave rectifier by setting the positive clamping threshold level to ground and the negative clamping threshold level to the negative supply. U1 is simply configured as a gain of two buffer and is required to buffer the input signal source, $\mathrm{V}_{\mathrm{IN}}$, from the dynamic input impedance presented by U 3 as well as match the signal delay of U2. U3 subtracts the output of the half-wave rectifier (U2) from the buffer output (U1) to produce the desired gain-of-two full-wave rectification. An optional trim network consisting of a potentiometer can be used to trim out any clamping offset error of U2. Precision $1 \%$ resistors for the gain controlling elements of U 1 and U 2 will typically maintain under $2 \%$ gain accuracy while values under $250 \Omega$ will not degrade the phase margin of these high speed amplifiers.

[^160]
## FEATURES

Usable Closed-Loop Gain Range: $\pm 1$ to $\pm 40$
Low Distortion: - 67 dBc (2nd) at 20 MHz
Small Signal Bandwidth: $190 \mathrm{MHz}\left(A_{v}=+3\right)$
Large Signal Bandwidth: 150 MHz at 4 V p-p
Settling Time: 10 ns to $\mathbf{0 . 1 \% ; 1 4} \mathbf{n s}$ to $0.02 \%$
Overdrive and Output Short Circuit Protected
Fast Overdrive Recovery
DC Nonlinearity 10 ppm

## APPLICATIONS

Driving Flash Converters
D/A Current-to-Voltage Converters
IF, Radar Processors
Baseband and Video Communications
Photodiode, CCD Preamps

PIN CONFIGURATION


NOTE: FOR BEST SETTLING TIME AND DISTORTION PERFORMANCE, USE OPTIONAL SUPPLY CONNECTIONS. PERFORMANCE INDICATED IN SPECIFICATIONS IS BASED ON SUPPLY CONNECTIONS TO THESE PINS.

## GENERAL DESCRIPTION

The AD9617 is a current feedback amplifier which utilizes a proprietary architecture to produce superior distortion and dc precision. It achieves this along with fast settling, very fast slew rate, wide bandwidth (both small signal and large signal) and exceptional signal fidelity. The device achieves -67 dBc 2 nd harmonic distortion at 20 MHz while maintaining 190 MHz small signal and 150 MHz large signal bandwidths.
These attributes position the AD9617 as an ideal choice for driving flash ADCs and buffering the latest generation of DACs. Optimized for applications requiring gain between $\pm 1$ to $\pm 15$, the AD9617 is unity gain stable without external compensation.

Additional benefits of the AD9617B and T grades include input offset voltage of $500 \mu \mathrm{~V}$ and temperature coefficient (TC) of $3 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$. These accuracy performance levels make the AD9617 an excellent choice for driving emerging high resolution ( $12-16$ bits), high speed analog-to-digital converters and flash converters.

The AD9617 offers outstanding performance in high fidelity, wide bandwidth applications in instrumentation ranging from network and spectrum analyzers to oscilloscopes and in military systems such as radar, SIGINT, and ESM systems. The superior slew rate, low overshoot and fast settling of the AD9617 allow the device to be used in pulse applications such as communications receivers and high speed ATE. Most monolithic op amps suffer in these precision pulse applications due to slew rate limiting.

The AD9617J operates over the range of 0 to $+70^{\circ} \mathrm{C}$ and is available in either an 8 -pin plastic mini-DIP or an 8 -lead plastic small outline package (SOIC). The AD9617A and B versions are rated over the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. The AD9617S and T versions are rated over the military temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ and are available processed to MIL-STD-883B.

[^161]ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

| Supply Voltages ( $\pm \mathrm{V}_{\text {S }}$ ) | V |
| :---: | :---: |
| Common Mode Input Voltage | $\pm \mathrm{V}_{\mathrm{S}}$ |
| Differential Input Voltage | 3 V |
| Continuous Output Current ${ }^{2}$ | 70 mA |
| Operating Temperature Ranges |  |
| AD9617JN/JR | 0 to $+70^{\circ} \mathrm{C}$ |
| AD9617AQ/BQ | $40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| AD9617SQ/TQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |

Storage Temperature
AD9617JN/JR . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$

$$
\mathrm{AD} 9617 \mathrm{AQ} / \mathrm{BQ} / \mathrm{SQ} / \mathrm{TQ} \ldots . . . . . . . . .{ }^{-6} 5^{\circ} \mathrm{C} \text { to }+150^{\circ} \mathrm{C}
$$

$$
\text { Junction Temperature }{ }^{3}
$$

AD9617JN/JR ..... $+150^{\circ} \mathrm{C}$
AD9617AQ/BQ/SQ/TQ ..... $+175^{\circ} \mathrm{C}$
Lead Soldering Temperature (10 Seconds) ..... $+300^{\circ} \mathrm{C}$

## DC ELECTRICAL CHARACTERISTICS (Unless otherisise noted, $A_{\mathrm{L}}=+3 ; \pm V_{s}= \pm 5 V_{;} ; \mathrm{R}_{\mathrm{F}}=400 \Omega ; \mathrm{R}_{\text {Lato }}=100 \Omega$ )

| Parameter | Conditions | Temp | Test Level | AD9617JN/JR |  |  | AD9617AQ/SQ |  |  | AD9617BQ/TQ |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| Input Offset Voltage ${ }^{4,5}$ |  | $+25^{\circ} \mathrm{C}$ | I | -1.1 | +0.5 | +2.2 | -1.1 | $+0.5$ | +2.2 | +0.0 | +0.5 | +1.1 | mV |
| Input Offset Voltage TC ${ }^{\text {s }}$ |  | Full | IV | -4 | +3 | +25 | -4 | +3 | +25 | -4 | +3 | +25 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Bias Current ${ }^{\text {s }}$ |  |  |  |  |  |  |  |  |  |  |  |  |  |
| Inverting |  | $+25^{\circ} \mathrm{C}$ | I | -50 | 0 | +50 | -50 | 0 | +50 | -25 | 0 | +25 | $\mu \mathrm{A}$ |
| Noninverting |  | $+25^{\circ} \mathrm{C}$ | I | -25 | +5 | +35 | -25 | +5 | +35 | -15 | +5 | +20 | $\mu \mathrm{A}$ |
| Input Bias Current TC ${ }^{\text {S }}$ |  |  |  |  |  |  |  |  |  |  |  |  |  |
| Noninverting |  | Full | IV | -50 | +30 | +125 | -50 | +30 | +125 | -50 | +30 | +125 | $n{ }^{\circ}{ }^{\circ} \mathrm{C}$ |
| Inverting |  | Full | IV | -50 | +50 | +150 | -50 | +50 | +150 | -50 | +50 | +150 | $n A /{ }^{\circ} \mathrm{C}$ |
| Input Resistance Noninverting |  | $+25^{\circ} \mathrm{C}$ | V |  | 60 |  |  | 60 |  |  | 60 |  | k $\Omega$ |
| Input Capacitance Noninverting |  | $+25^{\circ} \mathrm{C}$ | V |  | 1.5 |  |  | 1.5 |  |  | 1.5 |  | pF |
| Common-Mode Input Range ${ }^{6}$ | $\mathrm{T}=\mathrm{T}_{\text {max }}$ | $\leftarrow$ | II | $\pm 1.4$ | $\pm 1.5$ |  | $\pm 1.4$ | $\pm 1.5$ |  | $\pm 1.4$ | $\pm 1.5$ |  | V |
|  | $\mathrm{T}=\mathrm{T}_{\text {min }}$ to $+25^{\circ} \mathrm{C}$ | $\leftarrow$ | II | $\pm 1.7$ | $\pm 1.8$ |  | $\pm 1.7$ | $\pm 1.8$ |  | $\pm 1.7$ | $\pm 1.8$ |  | V |
| Common-Mode Rejection Ratio ${ }^{7}$ | $\mathrm{T}=\mathrm{T}_{\text {max }}$ | $\leftarrow$ | II | 44 | 48 |  | 44 | 48 |  | 44 | 48 |  | dB |
|  | $\mathrm{T}=\mathrm{T}_{\text {min }}$ to $+25^{\circ} \mathrm{C}$ | $\leftarrow$ | II | 50 | 53 |  | 50 | 53 |  | 50 | 53 |  | dB |
| Power Supply Rejection Ratio Open Loop Gain | $\Delta \mathbf{V}_{\text {S }}= \pm 5 \%$ | Full | II | 50 | 60 |  | 50 | 60 |  | 50 | 60 |  | dB |
|  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| $\mathrm{T}_{\mathrm{o}}$ | At dc | $+25^{\circ} \mathrm{C}$ | V |  | 500 |  |  | 500 |  |  | 500 |  | $\mathrm{k} \Omega$ |
| Nonlinearity | At dc | $+25^{\circ} \mathrm{C}$ | IV |  | 10 |  |  | 10 |  |  | 10 |  | ppm |
| Output Voltage Range |  | $+25^{\circ} \mathrm{C}$ | II | $\pm 3.4$ | $\pm 3.8$ |  | $\pm 3.4$ | $\pm 3.8$ |  | $\pm 3.4$ | $\pm 3.8$ |  | V |
| Output Impedance | At dc | $+25^{\circ} \mathrm{C}$ | V |  | 0.07 |  |  | 0.07 |  |  | 0.07 |  | $\Omega$ |
| Output Current ( $50 \Omega$ Load) | $\mathrm{T}=+25^{\circ} \mathrm{C}$ to $\mathrm{T}_{\text {max }}$ | $\leftarrow$ | II | 60 |  |  | 60 |  |  | 60 |  |  | mA |
|  | $\mathrm{T}=\mathrm{T}_{\text {min }}$ | $\leftarrow$ | II | 50 |  |  | 50 |  |  | 50 |  |  | mA |

AC ELECTRICAL CHARACTERISTICS (Unless otherwise notet, $A_{v}=+3_{;} \pm v_{s}= \pm 5 v_{;} R_{f}=400 \Omega_{;} R_{\text {Luan }}=100 \Omega$ )

| Parameter | Conditions | Temp | Test <br> Level | AD9617JN/JR |  |  | AD9617AQ/SQ. |  |  | AD9617BQ/TQ |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| FREQUENCY DOMAIN |  |  |  |  |  |  |  |  |  |  |  |  |  |
| Bandwidth ( -3 dB ) |  |  |  |  |  |  |  |  |  |  |  |  |  |
| Small Signal | $\mathrm{V}_{\text {OUT }} \leq 2 \mathrm{~V}$ p-p | Full | II | 145 | 190 |  | 145 | 190 |  | 145 | 190 |  | MHz |
| Large Signal | $\mathrm{V}_{\text {OUT }}=4 \mathrm{~V}$ p-p | Full | IV |  | 150 |  | 115 | 150 |  | 115 | 150 |  | MHz |
| Bandwidth Variation vs. $\mathrm{A}_{\mathbf{v}}$ | $\mathrm{A}_{\mathrm{V}}=-1$ to $\pm 15$ | $+25^{\circ} \mathrm{C}$ | V |  | 40 |  |  | 40 |  |  | 40 |  | MHz |
| Amplitude of Peaking ( $<50 \mathrm{MHz}$ ) | $\mathrm{T}=\mathrm{T}_{\text {min }}$ to $+25^{\circ} \mathrm{C}$ | $\leftarrow$ | II |  | 0 |  |  | 0 | 0.3 |  | 0 | 0.3 | dB |
|  | $\mathrm{T}=\mathrm{T}_{\text {max }}$ | $\leftarrow$ | II |  | 0 |  |  | 0 | 0.6 |  | 0 | 0.6 | dB |
| Amplitude of Peaking ( $>50 \mathrm{MHz}$ ) | $\mathrm{T}=\mathrm{T}_{\text {min }}$ to $+25^{\circ} \mathrm{C}$ | $\leftarrow$ | II |  | 0 |  |  | 0 | 0.8 |  | 0 | 0.8 | dB |
|  | $\mathrm{T}=\mathrm{T}_{\text {max }}$ | $\leftarrow$ | II |  | 0 |  |  | 0 | 1.0 |  | 0 | 1.0 | dB |
| Amplitude of Roll-Off ( $<75 \mathrm{MHz}$ ) |  | Full | II |  | 0.1 |  |  | 0.1 | 0.6 |  | 0.1 | 0.6 | dB |
| Phase Nonlinearity | dc to 75 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 0.5 |  |  | 0.5 |  |  | 0.5 |  | Degree |
| 2nd Harmonic Distortion | 2 V p-p; 4.3 MHz | Full | IV |  | -86 | -78 |  | -86 | -78 |  | -86 | -78 | dBc |
|  | 2 V p-p; 20 MHz | Full | IV |  | -67 | -59 |  | -67 | -59 |  | -67 | -59 | dBc |
|  | 2 V p-p; 60 MHz | Full | II |  | -51 | -43 |  | -51 | -43 |  | -51 | -43 | dBc |
| 3rd Harmonic Distortion | 2 V p-p; 4.3 MHz | Full | IV |  | -83 | -75 |  | -83 | -75 |  | -83 | -75 | dBc |
|  | 2 V p-p; 20 MHz | Full | IV |  | -69 | -61 |  | -69 | -61 |  | -69 | -61 | dBc |
|  | 2 V p-p; 60 MHz | Full | II |  | -54 | -46 |  | -54 | -46 |  | -54 | -46 | dBc |
| Input Noise Voltage | 10 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 1.2 |  |  | 1.2 |  |  | 1.2 |  | $\mathrm{nV} / \sqrt{(\mathrm{Hz})}$ |
| Inverting Input Noise Current | 10 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 29 |  |  | 29 |  |  | 29 |  | $\mathrm{pA} / \sqrt{(\mathrm{Hz})}$ |
| Average Equivalent Integrated Input Noise Voltage | 0.1 to 200 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 55 |  |  | 55 |  |  | 55 |  | $\mu \mathrm{V}, \mathrm{rms}$ |

AD9617

| Parameter | Conditions | Temp | Test <br> Level | AD9617JN/JR |  |  | AD9617AQ/SQ |  |  | AD9617BQ/TQ |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| TIME DOMAIN |  |  |  |  |  |  |  |  |  |  |  |  |  |
| Slew Rate | $\mathrm{V}_{\text {OUT }}=4 \mathrm{~V}$ Step | Full | IV |  | 1400 |  | 1100 | 1400 |  | 1100 | 1400 |  | $\mathrm{V} / \mu \mathrm{s}$ |
| Rise/Fall Time |  |  |  |  |  |  |  |  |  |  |  |  |  |
| $\mathrm{V}_{\text {OUt }}=2 \mathrm{~V}$ Step |  | Full | IV |  | 2.0 |  |  | 2.0 | 2.5 |  | 2.0 | 2.5 | ns |
| $\mathrm{V}_{\text {Out }}=4 \mathrm{~V}$ Step | $\mathrm{T}=+25^{\circ} \mathrm{C}$ to $\mathrm{T}_{\max }$ | $\leftarrow$ | IV |  | 2.4 |  |  | 2.4 | 3.3 |  | 2.4 | 3.3 | ns |
| $\mathrm{V}_{\text {Out }}=4 \mathrm{~V}$ Step | $\mathrm{T}=\mathrm{T}_{\text {min }}$ | $\leftarrow$ | IV |  | 2.4 |  |  | 2.4 | 3.5 |  | 2.4 | 3.5 | ns |
| Overshoot | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ Step | Full | IV |  | 3 |  |  | 3 | 14 |  | 3 | 14 | \% |
| Settling Time |  |  |  |  |  |  |  |  |  |  |  |  |  |
| To 0.1\% | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ Step | Full | IV |  | 10 |  |  | 10 | 15 |  | 10 | 15 | ns |
| To 0.02\% | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ Step | Full | IV |  | 14 |  |  | 14 | 23 |  | 14 | 23 | ns |
| To 0.1\% | $\mathrm{V}_{\text {OUT }}=4 \mathrm{~V}$ Step | Full | IV |  | 11 |  |  | 11 | 16 |  | 11 | 16 | ns |
| To 0.02\% | $\mathrm{V}_{\text {OUT }}=4 \mathrm{~V}$ Step | Full | IV |  | 16 |  |  |  | 24 |  | 16 | 24 | ns |
| $2 \times$ Overdrive. Recovery to |  |  |  |  |  |  |  |  |  |  |  |  |  |
| $\pm 2 \mathrm{mV}$ of Final Value | $\mathrm{V}_{\mathrm{IN}}=1.7 \mathrm{~V}$ Step | $+25^{\circ} \mathrm{C}$ | V |  | 50 |  |  | 50 |  |  | 50 |  |  |
| Propagation Delay |  | $+25^{\circ} \mathrm{C}$ | V |  | 2 |  |  | 2 |  |  | 2 |  | ns |
| Differential Gain ${ }^{8}$ |  | Full | V |  | <0.01 |  |  | <0.01 |  |  | <0.01 |  | \% |
| Differential Phase ${ }^{8}$ |  | Full | V |  | 0.01 |  |  | 0.01 |  |  | 0.01 |  | Degree |
| POWER SUPPLY REQUIREMENTS |  |  |  |  |  |  |  |  |  |  |  |  |  |
| Quiescent Current |  |  |  |  |  |  |  |  |  |  |  |  |  |
| $+\mathrm{I}_{5}$ |  | Full | II |  | 34 | 48 |  | 34 | 48 |  | 34 | 48 | mA |
| $-\mathrm{I}_{5}$ |  | Full | II |  | 34 | 48 |  | 34 | 48 |  | 34 | 48 | mA |

## NOTES

${ }^{1}$ Absolute maximum ratings are limiting values to be applied individually and beyond which the serviceability of the circuit may be impaired. Functional operability is not necessarily implied. Exposure to absolute maximum rating conditions for an extended period of time may affect device reliability.
${ }^{2}$ Output is short circuit protected to ground, but not to supplies. Continuous short circuit to ground may affect device reliability.
${ }^{3}$ Typical thermal impedances (part soldered onto board):
Mini-DIP: $\theta_{\mathrm{JA}}=140^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=30^{\circ} \mathrm{C} / \mathrm{W}$. Side Brazed/Cerdip: $\theta_{\mathrm{JA}}=110^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=20^{\circ} \mathrm{C} / \mathrm{W}$. SOIC Package: $\theta_{\mathrm{JA}}=150^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=30^{\circ} \mathrm{C} / \mathrm{W}$.
${ }^{4}$ Measured with respect to the inverting input.
${ }^{5}$ Typical is defined as the mean of the distribution.
${ }^{6}$ Measured in voltage follower configuration.
${ }^{7}$ Measured with $\mathrm{V}_{\text {IN }}= \pm 0.25 \mathrm{~V}$.
${ }^{8}$ Frequency $=4.3 \mathrm{MHz} ; \mathrm{R}_{\mathrm{L}}=150 \Omega ; \mathrm{A}_{\mathrm{V}}=+3$.
Specifications subject to change without notice.

## EXPLANATION OF TEST LEVELS

## Test Level

I - 100\% production tested.
II - $100 \%$ production tested at $+25^{\circ} \mathrm{C}$ and sample tested at specified temperatures. AC testing of J grade devices done on sample basis.
III - Sample tested only.
IV - Parameter is guaranteed by design and characterization testing.
V - Parameter is a typical value only.
VI - All devices are $100 \%$ production tested at $+25^{\circ} \mathrm{C}$. $100 \%$ production tested at temperature extremes for extended temperature devices; sample tested at temperature extremes for commercial/industrial devices.

## Die Connections



## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD9617JN | 0 to $+70^{\circ} \mathrm{C}$ | Plastic DIP | N-8 |
| AD9617JR | 0 to $+70^{\circ} \mathrm{C}$ | SOIC | R-8 |
| AD9617AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Cerdip | Q-8 |
| AD9617BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Cerdip | Q-8 |
| AD9617SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Cerdip | Q-8 |
| AD9617TQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Cerdip | Q-8 |

[^162] Low Distortion, Precision, Wide Bandwidth Op Amp AD9618*

## FEATURES

Usable Closed-Loop Gain Range: $\mathbf{+ 5 / - 1}$ to $\pm 100$
Low Distortion: -63 dBc (2nd) at 20 MHz
Small Signal Bandwidth: $160 \mathrm{MHz}\left(A_{v}=+10\right)$
Large Signal Bandwidth: 150 MHz at 5 V p-p
Settling Time: 10 ns to $\mathbf{0 . 1 \% ;} 14 \mathrm{~ns}$ to 0.02\%
Overdrive and Output Short Circuit Protected
Fast Overdrive Recovery
DC Nonlinearity 5 ppm

## APPLICATIONS

Driving Flash Converters
D/A Current to Voltage Converters
IF, Radar Processors
Baseband and Video Communications
Photodiode, CCD Preamps

PIN CONFIGURATION


NOTE: FOR BEST SETTLING TIME AND DISTORTION PERFORMANCE, USE OPTIONAL SUPPLY CONNECTIONS. PERFORMANCE INDICATED IN SPECIFICATIONS IS BASED ON SUPPLY CONNECTIONS TO THESE PINS.

## GENERAL DESCRIPTION

The AD9618 is a current feedback amplifier which utilizes a proprietary architecture to produce superior distortion and dc precision. It achieves this along with fast settling, very fast slew rate, wide bandwidth (both small signal and large signal), and exceptional signal fidelity. The device achieves -63 dBc 2 nd harmonic distortion at 20 MHz while maintaining 160 MHz small signal and 150 MHz large signal bandwidths.
These attributes position the AD9618 as an ideal choice for driving flash ADCs and buffering the latest generation of DACs. Optimized for applications requiring gain between $+5 /-1$ to $\pm 40$, the AD9618 is unity gain stable without external compensation.
Additional benefits of the AD9618B and T grades include input offset voltage of $500 \mu \mathrm{~V}$ and temperature coefficient (TC) of $3 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$. These accuracy performance levels make the AD9618 an excellent choice for driving emerging high resolution ( $12-16$ bits), high speed analog to digital converters and flash converters.
The AD9618 offers outstanding performance in high fidelity, wide bandwidth applications in instrumentation ranging from network and spectrum analyzers to oscilloscopes, and in military systems such as radar, SIGINT, and ESM systems. The superior slew rate, low overshoot, and fast settling of the AD9618 allow the device to be used in pulse applications such as communications receivers and high speed ATE. Most monolithic op amps suffer in these precision pulse applications due to slew rate limiting.

[^163]The AD9618J operates over the range of 0 to $+70^{\circ} \mathrm{C}$ and is available in either an 8 -pin plastic mini-DIP or an 8 lead plastic small outline package (SOIC). The AD9618A and B versions are rated over the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. The AD9618S and T versions are rated over the military temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$; and are available processed to MIL-STD-883B.

| ABSOLUTE MAXIMUM RATINGS ${ }^{1}$ |  |
| :---: | :---: |
| Supply Voltages ( $\pm \mathbf{V}_{\mathbf{S}}$ ) | V |
| Common Mode Input Voltage | $\pm \mathrm{V}_{\text {s }}$ |
| Differential Input Voltage | 3 V |
| Continuous Output Current ${ }^{2}$ | 70 mA |
| Operating Temperature Ranges |  |
| AD9618JN/JR | 0 to $+70^{\circ} \mathrm{C}$ |
| AD9618AQ/BQ | $40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| AD9618SQ/TQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |

ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

Storage Temperature
AD9618JN/JR
$-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$

AD9618AQ/BQ/SQ/TQ $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Junction Temperature ${ }^{3}$

AD9618JN/JR

$150^{\circ} \mathrm{C}$

AD9618AQ/BQ/SQ/TQ . . . . . . . . . . . . . . . . . . . . . $175^{\circ} \mathrm{C}$
Lead Soldering Temperature (10 Seconds)
$+300^{\circ} \mathrm{C}$

DC EL ECTRICAL CHARACTERISTICS (unless otherwise noted, $A_{V}=+10 ; \pm V_{S}= \pm 5 \mathrm{~V} ; \mathrm{R}_{\mathrm{F}}=1000 \Omega$; $R_{\text {LOAD }}=100 \Omega$ )

| Parameter | Conditions | Temp | Test Level | AD9618JN/JR |  |  | AD9618AQ/SQ |  |  | AD9618BQ/TQ |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min |  | Max | Min | Typ | Max | Min |  | Max |  |
| Input Offset Voltage ${ }^{4,5}$ |  | $+25^{\circ} \mathrm{C}$ | I | -1.1 | +0.5 | +2.2 | -1.1 | +0.5 | +2.2 | 0.0 | +0.5 | +1.1 | mV |
| Input Offset Voltage TC ${ }^{5}$ |  | Full | IV |  |  | +25 | -4 |  | +25 | -4 |  | +25 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Bias Current ${ }^{5}$ |  |  |  |  |  |  |  |  |  |  |  |  |  |
| Inverting |  | $+25^{\circ} \mathrm{C}$ | I | -45 | 0 | +45 | -45 | 0 | +45 | -20 |  | +20 | $\mu \mathrm{A}$ |
| Noninverting |  | $+25^{\circ} \mathrm{C}$ | I | -25 | +5 | +35 | -25 | +5 | +35 | -13 | +5 | +18 | $\mu \mathrm{A}$ |
| Input Bias Current TC ${ }^{5}$ |  |  |  |  |  |  |  |  |  |  |  |  |  |
| Noninverting |  | Full | IV | -50 | +30 | +125 | -50 | +30 | +125 | -50 | +30 | +125 | $n{ }^{(1 / 0} \mathrm{C}$ |
| Inverting |  | Full | IV | -50 | +40 | +130 | -50 | +40 | $+130$ | -50 | $+40$ | +130 | $n A^{\circ} \mathrm{C}$ |
|  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| Input Capacitance |  |  |  |  |  |  |  |  |  |  |  |  |  |
| Common Mode Input Range ${ }^{6}$ | $\mathrm{T}=\mathrm{T}_{\text {max }}$ |  | II | $\pm 1.0$ | $\pm 1.2$ |  | $\pm 1.0$ | $\pm 1.2$ |  | $\pm 1.0$ | $\pm 1.2$ |  | V |
|  | $\mathrm{T}=\mathrm{T}_{\text {min }}$ to $+25^{\circ} \mathrm{C}$ | $\leftarrow$ | II | $\pm 1.4$ | $\pm 1.5$ |  | $\pm 1.4$ | $\pm 1.5$ |  | $\pm 1.4$ | $\pm 1.5$ |  | V |
| Common Mode Rejection Ratio ${ }^{7}$ | $\mathrm{T}=\mathrm{T}_{\text {max }}$ |  | II | 44 | 48 |  |  | 48 |  | 44 | 48 |  | dB |
|  | $\mathrm{T}=+25^{\circ} \mathrm{C}$ | $\leftarrow$ | II | 48 | 52 |  |  | 52 |  |  | 52 |  | dB |
|  | $\mathrm{T}=\mathrm{T}_{\text {min }}$ | $\leftarrow$ | II | 50 | 54 |  |  | 54 |  | 50 | 54 |  | dB |
| Power Supply Rejection Ratio | $\Delta \mathrm{V}_{\mathrm{S}}= \pm 5 \%$ | Full | II |  | 60 |  |  | 60 |  |  | 60 |  | dB |
| Open Loop Gain |  |  |  |  |  |  |  |  |  |  |  |  |  |
| To | At dc | $+25^{\circ} \mathrm{C}$ | V |  | 3 |  |  |  |  |  | 5 |  | $\mathrm{M} \Omega$ |
| Nonlinearity | At dc | $+25^{\circ} \mathrm{C}$ | V |  | 5 |  |  | 5 |  |  | 5 |  | ppm |
| Output Voltage Range |  | $+25^{\circ} \mathrm{C}$ | II | $\pm 3.3$ | $\pm 3.7$ |  | $\pm 3.3$ | $\pm 3.7$ |  | $\pm 3.3$ | $\pm 3.7$ |  | V |
| Output Impedance | At dc | $+25^{\circ} \mathrm{C}$ | V |  | 0.08 |  |  | 0.08 |  |  | 0.08 |  | $\Omega$ |
| Output Current ( $50 \Omega$ Load) | $\mathrm{T}=+25^{\circ} \mathrm{C}$ to $\mathrm{T}_{\text {max }}$ | $\leftarrow$ | II | 60 |  |  | $60^{\circ}$ |  |  | 60 |  |  | mA |
|  | $\mathrm{T}=\mathrm{T}_{\text {min }}$ | $\leftarrow$ | II | 50 |  |  | 50 |  |  | 50 |  |  | mA |

AC ELECTRICAL CHARACTERISTICS Cunless dhemimse noted, $A_{i}=+10_{i} \pm v_{s}= \pm 5 V_{i} R_{f}=1 \mathrm{~K} \Omega_{i}$

| Parameter | Conditions | Temp | Test <br> Level | AD9618JN/JR |  |  | AD9618AQ/SQ |  |  | AD9618BQ/TQ |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max | Min |  | Max | Min |  | Max |  |
| FREQUENCY DOMAIN |  |  |  |  |  |  |  |  |  |  |  |  |  |
| Bandwidth ( -3 dB ) |  |  |  |  |  |  |  |  |  |  |  |  |  |
| Small Signal | $\mathrm{V}_{\text {OUT }} \leq 2 \mathrm{~V}$ p-p | Full | II | 130 | 160 |  | 130 | 160 |  | 130 | 160 |  | MHz |
| Large Signal | $\mathrm{V}_{\text {OUT }} \leq 5 \mathrm{~V}$ p-p | Full | IV |  | 150 |  | 120 | 150 |  | 120 | 150 |  | MHz |
| Bandwidth Variation vs. $\mathrm{A}_{\mathrm{v}}$ | $\mathrm{A}_{\mathrm{V}}=-1$ to $\pm 40$ | $+25^{\circ} \mathrm{C}$ | V |  | 35 |  |  | 35 |  |  | 35 |  | MHz |
| Amplitude of Peaking ( $<50 \mathrm{MHz}$ ) | $\mathrm{T}=\mathrm{T}_{\text {min }}$ to $+25^{\circ} \mathrm{C}$ | $\leftarrow$ | II |  | 0 |  |  | 0 | 0.4 |  | 0 | 0.4 | dB |
|  | $\mathrm{T}=\mathrm{T}_{\text {max }}$ | $\leftarrow$ | II |  | 0 |  |  | 0 | 0.7 |  | 0 | 0.7 | dB |
| Amplitude of Peaking ( $>50 \mathrm{MHz}$ ) | $\mathrm{T}=\mathrm{T}_{\text {min }}$ to $+25^{\circ} \mathrm{C}$ | $\leftarrow$ | II |  | 0 |  |  | 0 | 0.6 |  | 0 | 0.6 | dB |
|  | $\mathrm{T}=\mathrm{T}_{\text {max }}$ | $\leftarrow$ | II |  | 0 |  |  | 0 | 1.2 |  | 0 | 1.2 | dB |
| Amplitude of Roll-Off ( $<75 \mathrm{MHz}$ ) |  | Full | II |  | 0.5 |  |  | 0.5 | 1.2 |  | 0.5 | 1.2 | dB |
| Phase Nonlinearity | dc to 75 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 0.5 |  |  | 0.5 |  |  | 0.5 |  | Degree |
| 2nd Harmonic Distortion | 2 V p-p; 4.3 MHz | Full | IV |  | -83 | -75 |  | -83 | -75 |  | -83 | -75 | dBc |
|  | 2 V p-p; 20 MHz | Full | IV |  | -63 | -55 |  | -63 | -55 |  | -63 | -55 | dBc |
|  | 2 V p-p; 60 MHz | Full | II |  | -51 | -43 |  | -51 | -43 |  | -51 | -43 | dBc |
| 3rd Harmonic Distortion | 2 V p-p; 4.3 MHz | Full | IV |  | -85 | -77 |  | -85 | -77 |  | -85 | -77 | dBc |
|  | 2 V p-p; 20 MHz | Full | IV |  | -70 | -62 |  | -70 | -62 |  | -70 | -62 | dBc |
|  | 2 V p-p; 60 MHz | Full | II |  | -62 | -54 |  | -62 | -54 |  | -62 | -54 | dBc |
| Input Noise Voltage | 10 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 1.2 |  |  | 1.2 |  |  | 1.2 |  | $\mathrm{nV} / \sqrt{(\mathrm{Hz})}$ |
| Inverting Input Noise Current | 10 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 24 |  |  | 24 |  |  | 24 |  | $\mathrm{pA} / \sqrt{(\mathrm{Hz})}$ |


| Parameter | Conditions | Temp | Test <br> Level | AD9618JN/JR |  |  | AD9618AQ/SQ |  |  | AD9618BQ/TQ |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  |  | Max | Min |  | Max | Min |  | Max |  |
| Average Equivalent Integrated Input Noise Voltage | 0.1 to 200 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 38 |  |  | 38 |  |  | 38 |  | $\mu \mathrm{V}$, rms |
| TIME DOMAIN Slew Rate Rise/Fall Time | $\mathrm{V}_{\text {Out }}=4 \mathrm{~V}$ Step | Full | IV |  | 1800 |  | 1400 | 1800 |  | 1400 | 1800 |  | $\mathrm{V} / \mu \mathrm{s}$ |
| $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ Step |  | Full | IV |  | 2.2 |  |  | 2.2 | 2.6 |  | 2.2 | 2.6 | ns |
| $\mathrm{V}_{\text {OUT }}=5 \mathrm{~V}$ Step | $\mathrm{T}=+25^{\circ} \mathrm{C}$ to | $\leftarrow$ | IV |  | 2.3 |  |  | 2.3 | 2.8 |  | 2.3 | 2.8 |  |
|  | $\mathbf{T}=\mathrm{T}_{\text {min }}$ | $\leftarrow$ | IV |  | 2.3 |  |  | 2.3 | 3.1 |  | 2.3 | 3.1 |  |
| Overshoot | $\mathrm{V}_{\text {Our }}=2 \mathrm{~V}$ Step | Full | IV |  | 2 |  |  | , | 10 |  | 2 | 10 | \% |
| Settling Time To $0.1 \%$ |  |  |  |  |  |  |  |  |  |  |  |  |  |
| To 0.1\% To 0.02\% | $\mathrm{V}_{\text {Out }}=2 \mathrm{~V}$ Step $\mathrm{V}_{\text {Out }}=2 \mathrm{~V}$ Step | Full Full | IV |  | 9 14 |  |  |  | 15 23 |  | 9 14 | 15 23 |  |
| To 0.1\% | $\mathrm{V}_{\text {Out }}=4 \mathrm{~V}$ Step | Full | IV |  | 10 |  |  |  | 16 |  | 10 | 16 | ns |
| To 0.02\% | $\mathrm{V}_{\text {Out }}=4 \mathrm{~V}$ Step | Full | IV |  | 16 |  |  |  | 24 |  | 16 | 24 | ns |
| $2 \times$ Overdrive Recovery to $\pm 2 \mathrm{mV}$ of Final Value | $\mathrm{V}_{\text {IN }}=0.6 \mathrm{~V}$ Step | $+25^{\circ} \mathrm{C}$ | V |  | 50 |  |  | 50 |  |  | 50 |  | ns |
| Propagation Delay |  | $+25^{\circ} \mathrm{C}$ | V |  | 2 |  |  | 2 |  |  | 2 |  | ns |
| Differential Gain ${ }^{8}$ |  | Full | V |  | 0.01 |  |  | 0.01 |  |  | 0.01 |  |  |
| Differential Phase ${ }^{8}$ |  | Full | V |  | 0.02 |  |  | 0.02 |  |  | 0.02 |  | Degree |
| POWER SUPPLY REQUIREMENTS |  |  |  |  |  |  |  |  |  |  |  |  |  |
| $\qquad$ |  | Full | II |  | 31 | 43 |  | 31 | 43 |  | 31 | 43 | mA |
|  |  | Full | II |  | 31 | 43 |  | 31 | 43 |  | 31 | 43 | mA |

## NOTES

${ }^{1}$ Absolute maximum ratings are limiting values to be applied individually and beyond which the serviceability of the circuit may be impaired. Functional operability is not necessarily implied. Exposure to absolute maximum rating conditions for an extended period of time may affect device reliability.
${ }^{2}$ Output is short circuit protected to ground, but not to supplies. Continuous short circuit to ground may affect device reliability.
${ }^{3}$ Typical thermal impedances (part soldered onto board):
Mini-DIP: $\theta_{\mathrm{JA}}=140^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=30^{\circ} \mathrm{C} / \mathrm{W}$.
Side Brazed/Cerdip: $\theta_{\mathrm{JA}}=110^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=20^{\circ} \mathrm{C} / \mathrm{W}$.
SOIC Package: $\theta_{\mathrm{JA}}=150^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=30^{\circ} \mathrm{C} / \mathrm{W}$.
${ }^{4}$ Measured with respect to the inverting input.
${ }^{5}$ Typical is defined as the mean of the distribution.
${ }^{6}$ Measured in voltage follower configuration.
${ }^{7}$ Measured with $\mathrm{V}_{\mathrm{IN}}= \pm 0.25 \mathrm{~V}$.
${ }^{8}$ Frequency $=4.3 \mathrm{MHz} ; \mathrm{R}_{\mathrm{L}}=150 \Omega ; \mathrm{A}_{\mathrm{V}}=+10$.
Specifications subject to change without notice.

ORDERING GUIDE

## EXPLANATION OF TEST LEVELS

## Test Level

I - 100\% production tested.
II - $100 \%$ production tested at $+25^{\circ} \mathrm{C}$ and sample tested at specified temperatures. AC testing of J grade devices done on sample basis.
III - Sample tested only.
IV - Parameter is guaranteed by design and characterization testing.
V - Parameter is a typical value only.
VI - All devices are $100 \%$ production tested at $+25^{\circ} \mathrm{C} .100 \%$ production tested at temperature extremes for extended temperature devices; sample tested at temperature extremes for commercial/industrial devices.

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD9618JN | 0 to $+70^{\circ} \mathrm{C}$ | Plastic DIP | $\mathrm{N}-8$ |
| AD9618JR | 0 to $+70^{\circ} \mathrm{C}$ | SOIC | $\mathrm{R}-8$ |
| AD9618AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Cerdip | $\mathrm{Q}-8$ |
| AD9618BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Cerdip | $\mathrm{Q}-8$ |
| AD9618SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Cerdip | $\mathrm{Q}-8$ |
| AD9618TQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Cerdip | $\mathrm{Q}-8$ |

*For outline information see Package Information section.

## DIE CONNECTIONS



## FEATURES

Excellent Gain Accuracy: 0.994 V/V
Wide Bandwidth: 600 MHz
Slew Rate: $2200 \mathrm{~V} / \mu \mathrm{s}$
Ultralow Distortion:
-73 dBc@ 20 MHz
-91 dBc @ 2.3 MHz
Fast Settling Time: 8 ns to $0.02 \%$
Low Noise: $2.0 \mathrm{nV} / \sqrt{\mathrm{Hz}}$

## APPLICATIONS

IF/Communications
Impedance Transformations
Drives Flash ADCs
Line Driving

## GENERAL DESCRIPTION

The AD9620 is a monolithic, unity gain buffer amplifier that sets new standards in gain accuracy, wide bandwidth and low distortion. Its large signal bandwidth, ultralow distortion over frequency, and drive capabilities of the AD9620 make this buffer an ideal driver for flash ADCs. Other applications which require increased current drive at unity voltage gain, such as cable driving, also benefit from the AD9620's performance.
In addition to innovative (patent pending) feedback architecture, special packaging techniques improve dynamic performance by minimizing the reactive effects associated with standard packages. The result is -73 dBc harmonic suppression at 20 MHz , and -91 dBc at 2.3 MHz . The AD9620 also outperforms other amplifiers, including its predecessor AD9630, in terms of smallsignal pulse response and dc linearity. These features make the AD9620 the premier driver for high speed, high resolution ADCs.

## DIP CONFIGURATION



NC = NO CONNECT

Available in side-brazed ceramic DIP packages, the " $A$ " suffix unit is guaranteed for $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ operating temperatures; the " S " suffix device is guaranteed from $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. AD9620 die are de tested at $+25^{\circ} \mathrm{C}$.

[^164]ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

| Supply Voltages ( $\pm \mathrm{V}_{\mathrm{S}}$ ) | 7 V |
| :---: | :---: |
| Input Voltage Range | $\pm \mathrm{V}_{\mathrm{S}}$ |
| Continuous Output Current ${ }^{2}$ | 70 mA |
| Operating Temperature Ranges |  |
| AD9620AD | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| AD9620SD | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |

Storage Temperature
AD9620AD . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
AD9620SD . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Junction Temperature ${ }^{3}$. . . . . . . . . . . . . . . . . . . . . $+175^{\circ} \mathrm{C}$
Lead Soldering Temperature ( 10 seconds) ${ }^{4} \ldots . . . .+300^{\circ} \mathrm{C}$
DC ELECTRICAL CHARACTERISTICS (unless ottherwise noted, $\pm v_{S}= \pm 5 v_{;} R_{\text {R }}=50 \Omega, R_{\text {ita0 }}=100 \Omega$ )

| Parameter | Conditions | Temp | Test <br> Level | AD9620AD |  |  | AD9620SD |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max | Min | Typ | Max |  |
| DC SPECIFICATIONS |  |  |  |  |  |  |  |  |  |  |
| Output Offset Voltage |  | $+25^{\circ} \mathrm{C}$ | I | -8 | $\pm 2$ | +8 | -8 | $\pm 2$ | +8 | mV |
| Offset Voltage TC |  | Full | IV | -25 | $\pm 5$ | +25 | -25 | $\pm 5$ | +25 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Bias Current |  | $+25^{\circ} \mathrm{C}$ | I | -35 | $\pm 6$ | +35 | -35 | $\pm 6$ | +35 | $\mu \mathrm{A}$ |
| Bias Current TC |  | Full | IV | -150 | $\pm 50$ | +150 | -150 | $\pm 50$ | +150 | $\mathrm{nA} /{ }^{\circ} \mathrm{C}$ |
| Input Resistance |  | $+25^{\circ} \mathrm{C}$ to $\mathrm{T}_{\text {max }}$ | VI | 400 | 800 |  | 400 | 800 |  | $\mathrm{k} \Omega$ |
| Input Resistance |  | $\mathrm{T}_{\text {min }}$ | VI | 190 |  |  | 190 |  |  | $\mathrm{k} \Omega$ |
| Input Capacitance |  | $+25^{\circ} \mathrm{C}$ | V |  | 1.0 |  |  | 1.0 |  | pF |
| Gain | $\mathrm{V}_{\text {OUT }}=2 \mathrm{Vp-p}$ | Full | VI | 0.989 | 0.994 |  | 0.989 | 0.994 |  | V/V |
| Output Voltage Range |  | Full | VI | +2.8 |  | -2.8 | +2.8 |  | -2.8 | V |
| Output Current ( $50 \Omega$ Load) |  | Full | VI | 40 |  |  | 40 |  |  | mA |
| Output Impedance | At DC | $+25^{\circ} \mathrm{C}$ | V |  | 0.4 |  |  | 0.4 |  | $\Omega$ |
| Power Supply Rejection Ratio | $\Delta \mathrm{V}_{\mathrm{S}}= \pm 5 \%$ | Full | VI | 52 | 60 |  | 52 | 60 |  | dB |
| DC Nonlinearity | $\pm 2$ V Full Scale | $+25^{\circ} \mathrm{C}$ | VI |  | 0.005 |  |  | 0.005 |  | \% |
| FREQUENCY DOMAIN |  |  |  |  |  |  |  |  |  |  |
| Bandwidth ( -3 dB ) |  |  |  |  |  |  |  |  |  |  |
| Small Signal | $\mathrm{V}_{\text {OUT }}=\leq 0.7 \mathrm{~V}$ p-p | $\mathrm{T}_{\text {min }}$ to $+25^{\circ} \mathrm{C}$ | II |  | 600 |  | 320 | 600 |  | MHz |
| Small Signal | $\mathrm{V}_{\text {OUt }}=\leq 0.7 \mathrm{~V}$ p-p | $\mathrm{T}_{\text {max }}$ | II | 260 |  |  | 260 |  |  | MHz |
| Large Signal | $\mathrm{V}_{\text {OUT }}=4 \mathrm{~V}$ p-p | $\mathrm{T}_{\text {min }}$ to $+25^{\circ} \mathrm{C}$ | IV | 60 | 80 |  | 60 | 80 |  | MHz |
| Large Signal | $\mathrm{V}_{\text {OUT }}=4 \mathrm{~V}$ p-p | $\mathrm{T}_{\text {max }}$ | IV | 45 |  |  | 45 |  |  | MHz |
| Amplitude of Peaking | $\leq 150 \mathrm{MHz}$ | $\mathrm{T}_{\text {min }}$ to $+25^{\circ} \mathrm{C}$ | II |  | 0.8 | 1.5 |  | 0.8 | 1.5 | dB |
| Amplitude of Peaking | $\leq 150 \mathrm{MHz}$ | $\mathrm{T}_{\text {max }}$ | II |  | 1.5 | 2.2 |  | 1.5 | 2.2 | dB |
| Amplitude of Rolloff | $\leq 150 \mathrm{MHz}$ | Full | II |  | 0 | 0.3 |  | 0 | 0.3 | dB |
| Group Delay | DC to 150 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 0.75 |  |  | 0.75 |  | ns |
| Phase Nonlinearity | DC to 150 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 1.4 |  |  | 1.4 |  | Degrees |
| 2nd Harmonic Distortion | $2 \mathrm{~V} \mathrm{p}-\mathrm{p} ; 2.3 \mathrm{MHz}$ | $+25^{\circ} \mathrm{C}$ to $\mathrm{T}_{\text {max }}$ | IV |  | -91 | -82 |  | -91 | -82 | dBc |
|  | $2 \mathrm{~V} \mathrm{p}-\mathrm{p} ; 2.3 \mathrm{MHz}$ | $\mathrm{T}_{\text {min }}$ | IV |  | -81 | -73 |  | -81 | -73 | dBc |
|  | 2 V p-p; 20 MHz | Full | IV |  | -71 | -63 |  | -71 | -63 | dBc |
|  | $2 \mathrm{~V} \mathrm{p}-\mathrm{p} ; 60 \mathrm{MHz}$ | +25 | I |  | -69 | -60 |  | -69 | -60 | dBc |
|  | $2 \mathrm{~V} \mathrm{p}-\mathrm{p} ; 60 \mathrm{MHz}$ | $\mathrm{T}_{\text {min }}$ and $\mathrm{T}_{\text {max }}$ | V |  | -62 |  |  | -62 |  | dBc |
| 3rd Harmonic Distortion | 2 V p-p; 2.3 MHz | Full | IV |  | -94 | -86 |  | -94 | -86 | dBc |
|  | 2 V p-p; 20 MHz | Full | IV |  | -81 | -71 |  | -81 | -71 | dBc |
|  | 2 V p-p; 60 MHz | $+25^{\circ} \mathrm{C}$ | I |  | -60 | -52 |  | -60 | -52 |  |
| Spectral Input Noise Voltage | 10 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 2.0 |  |  | 2.0 |  | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| Average Equivalent Integrated Output Noise Voltage | 0.1 to 200 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 28 |  |  | 28 |  | $\mu \mathrm{V}$ |
| TIME DOMAIN |  |  |  |  |  |  |  |  |  |  |
| Slew Rate | $\mathrm{V}_{\text {OUT }}=4 \mathrm{~V}$ Step | $+25^{\circ} \mathrm{C}$ | IV | 1500 | 2200 |  | 1500 | 2200 |  | V/ $/ \mathrm{s}$ |
| Rise/Fall Time | $\mathrm{V}_{\text {OUT }}=1 \mathrm{~V}$ Step | $\mathrm{T}_{\text {min }}$ to $+25^{\circ} \mathrm{C}$ | IV |  | 0.8 | 1.2 |  | 0.8 | 1.2 | ns |
|  | $\mathrm{V}_{\text {OUT }}=1 \mathrm{~V}$ Step | $\mathrm{T}_{\text {max }}$ | IV |  | 1.1 | 1.5 |  | 1.1 | 1.5 | ns |
|  | $\mathrm{V}_{\text {OUT }}=4 \mathrm{~V}$ Step | $\mathrm{T}_{\text {min }}$ to $+25^{\circ} \mathrm{C}$ | IV |  | 1.7 | 2.5 |  | 1.7 | 2.5 | ns |
|  | $\mathrm{V}_{\text {OUT }}=4 \mathrm{~V}$ Step | $\mathrm{T}_{\text {max }}$ | IV |  | 2.3 | 3.4 |  | 2.3 | 3.4 | ns |
| Overshoot | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ Step | Full | IV |  | 3 | 12 |  | 3 | 12 | \% |
| Settling Time . |  |  |  |  |  |  |  |  |  |  |
| To 0.1\% | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ Step | Full | IV |  | 6 | 10 |  | 6 | 10 | ns |
| To 0.02\% | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ Step | Full | IV |  | 8 | 16 |  | 8 | 16 | ns |
| Differential Gain | 4.4 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 0.02 |  |  | 0.02 |  | \% |
| Differential Phase | 4.4 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 0.02 |  |  | 0.02 |  | Degrees |


|  | Conditions | Temp | Test Level | AD9620AD |  |  | AD9620SD |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Parameter |  |  |  | Min | Typ | Max | Min | Typ | Max |  |
| POWER SUPPLY REQUIREMENTS |  |  |  |  |  |  |  |  |  |  |
| Quiescent Current |  |  |  |  |  |  |  |  |  |  |
| $+\mathrm{I}_{\text {S }}$ | $+\mathrm{V}_{\mathrm{S}}=+5 \mathrm{~V}$ | Full | VI |  | 40 | 48 |  | 40 | 48 | mA |
| $-\mathrm{I}_{\mathrm{S}}$ | $-\mathrm{V}_{\mathrm{S}}=-5 \mathrm{~V}$ | Full | VI |  | 40 | 48 |  | 40 | 48 | mA |

NOTES
${ }^{1}$ Absolute maximum ratings are limiting values to be applied individually, and beyond which the serviceability of the circuit may be impaired. Functional operability is not necessarily implied. Exposure to absolute maximum rating conditions for an extended period of time may affect device reliability.
${ }^{2}$ Output is short-circuit protected to ground, but not to supplies. Continuous short circuit to ground may affect device reliability.
${ }^{3}$ Typical side-brazed thermal impedances (part soldered onto board): $\theta_{\mathrm{JA}}=110^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=20^{\circ} \mathrm{C} / \mathrm{W}$.
${ }^{4}$ External capacitor of AD9620 is attached with $62 \mathrm{Sn} / 36 \mathrm{~Pb} / 2 \mathrm{Ag}$ solder. Board attachment temperatures should be reviewed to insure the capacitor does not reflow during board mounting.
Specifications subject to change without notice.

## EXPLANATION OF TEST LEVELS

## Test Level

I - $\quad 100 \%$ production tested.
II - $\quad 100 \%$ production tested at $+25^{\circ} \mathrm{C}$, and sample tested at specified temperatures.
III - Sample tested only.
IV - Parameter is guaranteed by design and characterization testing.
V - Parameter is a typical value only.
VI - All devices are $100 \%$ production tested at $+25^{\circ} \mathrm{C}$. $100 \%$ production tested at temperature extremes for extended temperature devices; sample tested at temperature extremes for commercial/industrial devices.


ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD9620AD | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin DIP | D-8 |
| AD9620SD | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin DIP | D-8 |
| AD9620 Chips | $+25^{\circ} \mathrm{C}$ | Dice |  |

*For outline information see Package Information section.


AD9620 Bonding Diagram

## THEORY OF OPERATION

The AD9620 is a wide bandwidth, unity gain buffer amplifier that utilizes innovative (patent pending) voltage feedback architecture. Large loop gain and high slew rate significantly improve dc linearity and large signal bandwidth when compared with that achieved with more conventional designs.
Its large-signal bandwidth compares favorably with competitive devices of open-loop design without their limitations. Open-loop devices often sacrifice dc linearity and introduce frequency distortion when driving low load impedances; the AD9620 does not. Its design yields low distortion products that are relatively constant for any resistive load greater than 50 ohms.

The AD9620 will satisfy any high performance analog signal processing application requiring isolation or current boosting between the signal source and load. Its combination of high input resistance and low capacitance, dc precision, and exceptional dynamic characteristics sets a new standard in performance that has no equal.
Excessive peaking may occur when using the AD9620 to directly drive loads with more than 3 pF of capacitance. To prevent this, a small value of resistance $\left(\mathbf{R}_{S}\right)$ should be placed in series with the buffer output.

## FEATURES

350 MHz Small Signal Bandwidth
130 MHz Large Signal BW (4 V p-p)
High Slew Rate: 1200 V/ $\mu \mathrm{s}$
Fast Settling: 11 ns to $0.01 \% / 7$ ns to $0.1 \%$
$\pm 3$ V Supply Operation
APPLICATIONS
ADC Input Driver
Differential Amplifiers
IF/RF Amplifiers
Pulse Amplifiers
Professional Video
DAC Current-to-Voltage
Baseband and Video Communications
Pin Diode Receivers
Active Filters/Integrators/Log Amps

## GENERAL DESCRIPTION

The AD9621 is one of a family of very high speed and wide bandwidth amplifiers utilizing a voltage feedback architecture. These amplifiers define a new level of performance for voltage feedback amplifiers, especially in the categories of large signal bandwidth, slew rate, settling, and low noise.
Proprietary design architectures have resulted in an amplifier family that combines the most attractive attributes of both current feedback and voltage feedback amplifiers. The AD9621 exhibits extraordinarily accurate and fast pulse response characteristics ( 7 ns settling to $0.1 \%$ ) as well as extremely wide small and large signal bandwidth previously found only in current feedback amplifiers. When combined with balanced high impedance inputs and low input noise current more common to voltage feedback architectures, the AD9621 offers performance not previously available in a monolithic operational amplifier.

## CONNECTION DIAGRAM



Other members of the AD962X amplifier family are the AD9622 ( $\mathrm{G}=+2$ ), AD9623 ( $\mathrm{G}=+4$ ), and the AD9624 ( $\mathrm{G}=+6$ ). A separate data sheet is available from Analog Devices for each model. Each generic device has been designed for a different minimum stable gain setting, allowing users flexibility in optimizing system performance. Dynamic performance specifications such as slew rate, settling time, and distortion vary from model to model. The table below summarizes key performance attributes for the AD962X family and can be used as a selection guide.
The AD9621 is offered in industrial and military temperature ranges. Industrial versions are available in plastic DIP, SOIC, and cerdip; MIL versions are packaged in cerdips.

## PRODUCT HIGHLIGHTS

1. Wide Large Signal Bandwidth
2. High Slew Rate
3. Fast Settling
4. Output Short-Circuit Protected
*Protected by U.S. Patent $\mathbf{5 , 1 5 0 , 0 7 4}$ and others pending.

| Parameter | AD9621 | AD9622 | AD9623 | AD9624 | Units |
| :--- | :--- | :--- | :--- | :--- | :--- |
| Minimum Stable Gain | +1 | +2 | +4 | +6 | $\mathrm{~V} / \mathrm{V}$ |
| Harmonic Distortion (20 MHz) | -52 | -66 | -64 | -66 | dB |
| Large Signal Bandwidth (4 V p-p) | 130 | 160 | 190 | 200 | MHz |
| SSBW (0.5 V p-p) | 350 | 220 | 270 | 300 | MHz |
| Slew Rate | 1200 | 1500 | 2100 | 2200 | $\mathrm{~V} / \mu \mathrm{s}$ |
| Rise/Fall Time (0.5 V Step) | 2.4 | 1.7 | 1.6 | 1.5 | ns |
| Settling Time (to $0.1 \% / 0.01 \%)$ | $7 / 11$ | $8 / 14$ | $8 / 14$ | $8 / 14$ | ns |
| Input Noise ( $0.1 \mathrm{MHz}-200 \mathrm{MHz})$ | 80 | 49 | 36 | 32 | $\mu \mathrm{~V}$ rms |

This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

| Parameter | Conditions | Temp | Test <br> Level | AD9621AN/AQ/AR |  |  | AD9621SQ |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max | Min | Typ | Max |  |
| DC SPECIFICATIONS ${ }^{1}$ |  |  |  |  |  |  |  |  |  |  |
| Input Offset Voltage |  | $+25^{\circ} \mathrm{C}$ | I | -12 | $\pm 2$ | +12 | -12 | $\pm 2$ | +12 | mV |
|  |  | Full | VI | -15 |  | +15 | -15 |  | +15 | mV |
| Input Bias Current |  | $+25^{\circ} \mathrm{C}$ | I |  | 7 | 16 |  | 7 | 16 | $\mu \mathrm{A}$ |
|  |  | Full | VI | -20 |  | +20 | -20 |  | +20 | $\mu \mathrm{A}$ |
| Input Bias Current TC |  | Full | V |  | 35 |  |  | 35 |  | $\mathrm{nA} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current |  | $+25^{\circ} \mathrm{C}$ | I | -2.0 | $\pm 0.3$ | +2.0 | -2.0 |  | +2.0 | $\mu \mathrm{A}$ |
|  |  | Full | VI | -3.0 |  | +3.0 | -3.0 |  | +3.0 | $\mu \mathrm{A}$ |
| Offset Current TC |  | Full | V |  | 2.5 |  |  | 2.5 |  | $n \mathrm{~A} /{ }^{\circ} \mathrm{C}$ |
| Input Resistance |  | $+25^{\circ} \mathrm{C}$ | V |  | 500 |  |  | 500 |  | $\mathrm{k} \Omega$ |
| Input Capacitance |  | $+25^{\circ} \mathrm{C}$ | V |  | 1.2 |  |  | 1.2 |  | pF |
| Common-Mode Range |  | Full | VI | $\pm 3.0$ | $\pm 3.4$ |  | $\pm 3.0$ | $\pm 3.4$ |  | V |
| Common-Mode Rejection Ratio | $\Delta V_{C M}=1 \mathrm{~V}$ | $+25^{\circ} \mathrm{C}$ | I | 46 | 49 |  | 46 | 49 |  | dB |
| Open Loop Gain | $\mathrm{V}_{\text {OUT }}= \pm 2 \mathrm{~V} \text { p-p }$ | $+25^{\circ} \mathrm{C}$ | V |  | 56 |  |  | 56 |  | $\mathrm{dB}$ |
| Output Voltage Range |  | Full | VI | $\pm 3.0$ | $\pm 3.4$ |  | $\pm 3.0$ | $\pm 3.4$ |  | V |
| Output Current |  | Full | VI | 60 | 70 |  | 60 |  |  | $\mathrm{mA}$ |
| Output Resistance |  | $+25^{\circ} \mathrm{C}$ | V |  |  |  |  |  |  |  |
| FREQUENCY DOMAIN |  |  |  |  |  |  |  |  |  |  |
| Bandwidth ( -3 dB ) |  |  |  |  |  |  |  |  |  |  |
| Small Signal | $\mathrm{V}_{\text {OUT }} \leq 0.4 \mathrm{~V}$ p-p | Full | II | 230 | 350 |  | 230 | 350 |  | MHz |
| Large Signal | $\mathrm{V}_{\text {OUT }} \leq 4.0 \mathrm{~V}$ p-p | Full | V |  | 130 |  |  | 130 |  | MHz |
| Amplitude of Peaking | Full Spectrum | Full | II |  | 0.1 | 1.2 |  | 0.1 | 1.2 | dB |
| Amplitude of Roll-off | $\leq 100 \mathrm{MHz}$ | Full | II |  | 0 | 0.6 |  | 0 | 0.6 | dB |
| Phase Nonlinearity | dc to 100 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 1.1 |  |  | 1.1 |  | Degree |
| 2nd Harmonic Distortion | $2 \mathrm{~V} \mathrm{p-p;} 20 \mathrm{MHz}$ | Full | II |  | -55 | -44 |  | -55 | -44 | dBc |
| 3rd Harmonic Distortion | 2 V p-p; 20 MHz | Full | II |  | -52 | -43 |  | -52 | -43 | dBc |
| Common-Mode Rejection Mode | @ 20 MHz | $+25^{\circ} \mathrm{C}$ | V |  | +28 |  |  | +28 |  | dB |
| Spectral Input Noise Voltage | 1 to 200 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 5.6 |  |  | 5.6 |  | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| Spectral Input Noise Current | 1 to 200 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 3.6 |  |  | 3.6 |  | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
| Average Equivalent Integrated Input Noise Voltage | 0.1 to 200 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 80 |  |  | 80 |  | $\mu \mathrm{V}$ rms |
| TIME DOMAIN |  |  |  |  |  |  |  |  |  |  |
| Slew Rate | $\mathrm{V}_{\text {OUT }}=5 \mathrm{~V}$ Step | Full | IV | 850 | 1200 |  | 850 | 1200 |  | V/ $/ \mathrm{s}$ |
| Rise/Fall Time | $\mathrm{V}_{\text {OUT }}=0.5 \mathrm{~V}$ Step | $+25^{\circ} \mathrm{C}$ | V |  | 2.4 |  |  | 2.4 |  | ns |
|  | $\mathrm{V}_{\text {OUT }}=5 \mathrm{~V}$ Step | Full | IV |  | 4.8 | 7 |  | 4.8 | 7 |  |
| Overshoot | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ Step | Full | IV |  | 0 | 15 |  | 0 | 15 | \% |
| Settling Time |  |  |  |  |  |  |  |  |  |  |
| To 0.1\% | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ Step | $+25^{\circ} \mathrm{C}$ | V |  | 7 |  |  | 7 |  | ns |
| To 0.01\% | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ Step | Full | IV |  |  | 15 |  | 11 | 15 | ns |
| To 0.1\% ${ }^{2}$ | $\mathrm{V}_{\text {OUT }}=4 \mathrm{~V}$ Step | $+25^{\circ} \mathrm{C}$ | V |  | 9 |  |  | 9 |  | ns |
| To 0.01 ${ }^{\text {2 }}$ | $\mathrm{V}_{\text {OUT }}=4 \mathrm{~V}$ Step | $+25^{\circ} \mathrm{C}$ | V |  | 13 |  |  | 13 |  | ns |
| Overdrive Recovery | 1.5 x to $\pm 2 \mathrm{mV}$ | $+25^{\circ} \mathrm{C}$ | V |  | 50 |  |  | 50 |  | ns |
| Differential Gain (4.3 MHz) | $\mathrm{R}_{\mathrm{L}}=150 \Omega$ | $+25^{\circ} \mathrm{C}$ | V |  | 0.01 |  |  | 0.01 |  | \% |
| Differential Phase (4.3 MHz) | $\mathrm{R}_{\mathrm{L}}=150 \Omega$ | $+25^{\circ} \mathrm{C}$ | V |  | <0.01 |  |  | <0.01 |  | Degree |
| POWER SUPPLY REQUIREMENTS ${ }^{1}$ |  |  |  |  |  |  |  |  |  |  |
| Supply Voltage ( $\pm \mathrm{V}_{\text {S }}$ ) |  | Full | IV | 3.0 | 5.0 | 5.5 | 3.0 | 5.0 | 5.5 | V |
| Quiescent Current |  |  |  |  |  |  |  |  |  |  |
| $+\mathrm{I}_{5}$ | $+\mathrm{V}_{\mathrm{s}}=+5 \mathrm{~V}$ | Full | VI |  | 23 | 29 |  | 23 | 29 | mA |
| $-I_{s}$ | $-\mathrm{V}_{\mathrm{s}}=-5 \mathrm{~V}$ | Full | VI |  | 23 | 29 |  | 23 | 29 | mA |
| Power Supply Rejection Ratio | $\Delta \mathrm{V}_{\mathrm{S}}=0.5 \mathrm{~V}$ | $+25^{\circ} \mathrm{C}$ | I | 54 | 66 |  | 54 | 66 |  | dB |

[^165]
## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

Supply Voltages ( $\pm \mathrm{V}_{\mathrm{S}}$ ) . . . . . . . . . . . . . . . . . . . . . . . $\pm 6$ V
Common-Mode Input Voltage . . . . . . . . . . . . . . . . . . . $\pm \mathrm{V}_{\text {S }}$
Differential Input Voltage . . . . . . . . . . . . . . . . . . . . . . 6 V
Continuous Output Current ${ }^{2}$. . . . . . . . . . . . . . . . . . . 90 mA
Operating Temperature Ranges
AN, AQ, AR . . . . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$

SQ . . . . . . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature
Ceramic . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Plastic . . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Junction Temperature
Ceramic ${ }^{3}$
$+175^{\circ} \mathrm{C}$
Plastic ${ }^{3}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . $+150^{\circ} \mathrm{C}$
Lead Soldering Temperature ( 1 minute $)^{4} \ldots \ldots . . . . .+220^{\circ} \mathrm{C}$
NOTES
${ }^{1}$ Absolute maximum ratings are limiting values to be applied individually, and beyond which the serviceability of the circuit may be impaired. Functional operability is not necessarily implied. Exposure to absolute maximum rating conditions for an extended period of time may affect device reliability.
${ }^{2}$ Output is short-circuit protected; for maximum reliability, 90 mA continuous current should not be exceeded.
${ }^{3}$ Typical thermal impedances (part soldered onto board; no air flow):
Ceramic DIP: $\theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=30^{\circ} \mathrm{C} / \mathrm{W}$
Plastic SOIC: $\theta_{\mathrm{JA}}=125^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=45^{\circ} \mathrm{C} / \mathrm{W}$
Plastic DIP $\quad \theta_{\mathrm{JA}}=90^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=45^{\circ} \mathrm{C} / \mathrm{W}$
${ }^{4}$ Temperature shown is for surface mount devices, mounted by vapor phase soldering. Throughhole devices (ceramic and plastic DIPs) can be soldered at $+300^{\circ} \mathrm{C}$ for 10 seconds.

## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD9621AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | $\mathrm{N}-8$ |
| AD9621AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Cerdip | Q-8 |
| AD9621AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin SOIC | R-8 |
| AD9621SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Cerdip | Q-8 |

*For outline information see Package Information section.

## EXPLANATION OF TEST LEVELS

## Test Level

I - $100 \%$ production tested.
II $-100 \%$ production tested at $+25^{\circ} \mathrm{C}$, and sample tested at specified temperatures. AC testing of " A " grade devices done on sample basis.
III - Sample tested only.
IV - Parameter is guaranteed by design and characterization testing.
V - Parameter is a typical value only.
VI - All devices are $100 \%$ production tested at $+25^{\circ} \mathrm{C}$. $100 \%$ production tested at temperature extremes for extended temperature devices; sample tested at temperature extremes for commercial/industrial devices.


Chip Layout

## THEORY OF OPERATION

The AD9621 is a wide bandwidth, unity gain stable voltage feedback amplifier. Since its open-loop frequency response follows the conventional 6 dB /octave roll-off, its gain bandwidth product is basically constant. Increasing its closed-loop gain results in a corresponding decrease in small signal bandwidth. The AD9621 typically maintains a 55 degree unity loop gain phase margin. This high margin minimizes the effects of signal and noise peaking.

## Feedback Resistor Choice

At minimum stable gain ( +1 ), the AD9621 provides optimum dynamic performance with $\mathrm{R}_{\mathrm{F}} \cong 51 \Omega$. This resistor acts only as a parasitic suppressor against damped $\mathrm{R}_{\mathrm{F}}$ oscillations that can occur due to lead (input, feedback) inductance and parasitic capacitance. For settling accuracy to $0.1 \%$ or less, this resistor should not be required if layout guidelines are closely followed. This value for $\mathrm{R}_{\mathrm{F}}$ provides the best combination of wide bandwidth, low parasitic peaking, and fast settling time.
When the AD9621 is used in the transimpedance (I-to-V) mode, such as for photo-diode detection, the value for $R_{F}$ and diode capacitance $\left(\mathrm{C}_{\mathrm{I}}\right)$ are usually known. See Figure 1. Generally, the value of $R_{F}$ selected will be in the $k \Omega$ range, and a shunt capacitor ( $\mathrm{C}_{\mathrm{F}}$ ) across $\mathrm{R}_{\mathrm{F}}$ will be required to maintain good amplifier stability. The value of $\mathrm{C}_{\mathrm{F}}$ required to maintain $<1 \mathrm{~dB}$ of peaking can be estimated as:

$$
C_{F} \cong\left[\left(2 \omega_{o} C_{I} R_{F}-1\right) / \omega_{O}^{2} R_{F}^{2}\right]^{1 / 2} \left\lvert\, \begin{aligned}
& \\
& R_{F} \geq 1 k \Omega
\end{aligned}\right.
$$

where $\omega_{\mathrm{O}}$ is equal to the unity gain bandwidth product of the amplifier in RAD/sec, and $\mathrm{C}_{\mathrm{I}}$ is the equivalent total input capacitance at the inverting input. Typically $\omega_{\mathrm{O}}$ is $700 \times 10^{6} \mathrm{RAD} /$ sec (See Open Loop Frequency Response curve).
As an example, choosing $R_{F}$ of $10 \mathrm{k} \Omega$ and $C_{I}$ of 5 pF , requires $\mathrm{C}_{\mathrm{F}}$ to be 1.1 pF (Note: $\mathrm{C}_{\mathrm{I}}$ includes both the source and parasitic circuit capacitance). The bandwidth of the amplifier can be estimated using the $\mathrm{C}_{\mathrm{F}}$ calculated as:

$$
f_{3} d B \cong \frac{1.6}{2 \pi R_{F} C_{F}}
$$

For general voltage gain applications, the amplifier bandwidth can be estimated as:

$$
f_{3} d B \cong \frac{\omega_{O}}{1+\left(\frac{R_{F}}{R_{G}}\right)}
$$

This estimation loses accuracy for gains approaching $+2 /-1$ or lower due to the amplifier's damping factor. For these "low gain" cases, the bandwidth will actually extend beyond the calculated value. See Closed Loop BW plots.

As a rule of thumb, capacitor $C_{F}$ will not be required if:

$$
\left(R_{F} \| R_{G}\right) C_{I} \leq \frac{N G}{4 \omega_{O}}
$$

where $N G$ is the Noise Gain $\left(1+R_{F} / R_{G}\right)$ of the circuit. For most voltage gain applications, this should be the case.

ANALOG

## FEATURES

220 MHz Small Signal Bandwidth 160 MHz Large Signal BW (4 V p-p) High Slew Rate: 1500 V/ $\mu \mathrm{s}$
Low Distortion: - $\mathbf{6 6}$ dB @ $\mathbf{2 0} \mathbf{~ M H z}$
Fast Settling: 14 ns to $0.01 \%$
$3.5 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ Spectral Noise Density $\pm 3$ V Supply Operation
APPLICATIONS
ADC Input Signal Amplifier
Differential Amplifiers
IF/RF Amplifiers
Pulse Amplifiers
Professional Video
DAC Current-to-Voltage
Baseband and Video Communications
Active Filters/Integrators/Log Amps

## GENERAL DESCRIPTION

The AD9622 is one of a family of very high speed and wide bandwidth amplifiers utilizing a voltage feedback architecture. These amplifiers define a new level of performance for voltage feedback amplifiers, especially in the categories of large signal bandwidth, slew rate, settling, low distortion, and low noise.
Proprietary design architectures have resulted in an amplifier family that combines the most attractive attributes of both current feedback and voltage feedback amplifiers. The AD9622 exhibits extraordinarily accurate and fast pulse response characteristics ( 8 ns settling to $0.1 \%$ ) as well as extremely wide small and large signal bandwidth previously found only in current feedback amplifiers. When combined with balanced high impedance inputs and low input noise more common to voltage feedback architectures, the AD9622 offers performance not previously available in a monolithic operational amplifier.


Other members of the AD962X amplifier family are the AD9621 ( $\mathrm{G}=+1$ ), AD9623 ( $\mathrm{G}=+4$ ), and the AD9624 $(G=+6)$. A separate data sheet is available from Analog Devices for each model. Each generic device has been designed for a different minimum stable gain setting, allowing users flexibility in optimizing system performance. Dynamic performance specifications such as slew rate, settling time, and distortion vary from model to model. The table below summarizes key performance attributes for the AD962X family and can be used as a selection guide.
The AD9622 is offered in industrial and military temperature ranges. Industrial versions are available in plastic DIP, SOIC, and cerdip; MIL versions are packaged in cerdips.

## PRODUCT HIGHLIGHTS

1. Wide Large Signal Bandwidth
2. High Slew Rate
3. Fast Settling
4. Low Distortion
5. Output Short-Circuit Protected
6. Low Intermodulation Distortion of High Frequencies
*Protected by U.S. Patent $\mathbf{5 , 1 5 0 , 0 7 4}$ and others pending.

| Parameter | AD9621 | AD9622 | AD9623 | AD9624 | Units |
| :--- | :--- | :--- | :--- | :--- | :--- |
| Minimum Stable Gain | +1 | +2 | +4 | +6 | V/V |
| Harmonic Distortion (20 MHz) | -52 | -66 | -64 | -66 | dB |
| Large Signal Bandwidth (4 V p-p) | 130 | 160 | 190 | 200 | MHz |
| SSBW (0.5 V p-p) | 350 | 220 | 270 | 300 | MHz |
| Slew Rate | 1200 | 1500 | 2100 | 2200 | $\mathrm{~V} / \mu \mathrm{s}$ |
| Rise/Fall Time (0.5 V Step) | 2.4 | 1.7 | 1.6 | 1.5 | ns |
| Settling Time (to 0.1\%/0.01\%) | $7 / 11$ | $8 / 14$ | $8 / 14$ | $8 / 14$ | ns |
| Input Noise (0.1 MHz-200 MHz) | 80 | 49 | 36 | 32 | $\mu \mathrm{~V}$ rms |

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| Parameter | Conditions | Temp | Test Level | AD9622AN/AQ/AR |  |  | AD9622SQ |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max | Min | Typ | Max |  |
| DC SPECIFICATIONS ${ }^{1}$ |  |  |  |  |  |  |  |  |  |  |
| Input Offset Voltage |  | $+25^{\circ} \mathrm{C}$ | I | -10 | $\pm 2$ | +10 | -10 | $\pm 2$ | +10 | mV |
|  |  | Full | VI | -12 |  | +12 | -12 |  | +12 | mV |
| Input Bias Current |  | $+25^{\circ} \mathrm{C}$ | I |  | 7 | 14 |  | 7 | 14 | $\mu \mathrm{A}$ |
|  |  | Full | VI |  |  | 18 |  |  | 18 | $\mu \mathrm{A}$ |
| Bias Current TC |  | Full | V |  | 35 |  |  | 35 |  | $\mathrm{nA} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current |  | $+25^{\circ} \mathrm{C}$ | I | -2 | $\pm 0.3$ | +2 | -2 | $\pm 0.3$ | +2 | $\mu \mathrm{A}$ |
|  |  | Full | VI | -3 |  | +3 | -3 |  | +3 | $\mu \mathrm{A}$ |
| Offset Current TC |  | Full | V |  | 2.5 |  |  | 2.5 |  | $\mathrm{nA} /{ }^{\circ} \mathrm{C}$ |
| Input Resistance |  | $+25^{\circ} \mathrm{C}$ | V |  | 500 |  |  | 500 |  | k $\Omega$ |
| Input Capacitance |  | $+25^{\circ} \mathrm{C}$ | V |  | 1.2 |  |  | 1.2 |  | pF |
| Common-Mode Range |  | Full | VI | $\pm 3.0$ | $\pm 3.4$ |  | $\pm 3.0$ | $\pm 3.4$ |  | V |
| Common-Mode Rejection Ratio | $\Delta \mathrm{V}_{\mathrm{CM}}=1 \mathrm{~V}$ | $+25^{\circ} \mathrm{C}$ | I | 47 | 57 |  | 47 | 57 |  | dB |
| Open-Loop Gain | $\mathrm{V}_{\text {OUT }}= \pm 2 \mathrm{~V}$ p-p | $+25^{\circ} \mathrm{C}$ | V |  | 60 |  |  | 60 |  | dB |
| Output Voltage Range |  | Full | VI | $\pm 3.0$ | $\pm 3.4$ |  | $\pm 3.0$ | $\pm 3.4$ |  | V |
| Output Current |  | Full | VI | 60 | 70 |  | 60 | 70 |  | mA |
| Output Resistance |  | $+25^{\circ} \mathrm{C}$ | V |  | 0.3 |  |  | 0.3 |  | $\Omega$ |
| FREQUENCY DOMAIN |  |  |  |  |  |  |  |  |  |  |
| Bandwidth ( -3 dB ) |  |  |  |  |  |  |  |  |  |  |
| Small Signal | $\mathrm{V}_{\text {Out }} \leq 0.4 \mathrm{~V}$ p-p | Full | II | 160 | 220 |  | 160 | 220 |  | MHz |
| Large Signal ${ }^{2}$ | $\mathrm{V}_{\text {Out }}=4 \mathrm{~V}$ p-p | $+25^{\circ} \mathrm{C}$ | V |  | 160 |  |  | 160 |  | MHz |
| Amplitude of Peaking | Full Spectrum | Full | II |  | 0.2 | 1.2 |  | 0.2 | 1.2 | dB |
| Amplitude of Roll-off | DC to 100 MHz | Full | II |  | 0 | 0.8 |  | 0 | 0.8 | dB |
| Phase Nonlinearity | 0.3 MHz to 100 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 1.3 |  |  | 1.3 |  | degree |
| 2nd Harmonic Distortion | 2 V p-p; 20 MHz | Full | II |  | -66 | -56 |  | -66 | -56 | dBc |
| 3rd Harmonic Distortion | 2 V p-p; 20 MHz | Full | II |  | -68 | -56 |  | -68 | -56 | dBc |
| Common-Mode Rejection Ratio | @ 20 MHz | $+25^{\circ} \mathrm{C}$ | V |  | +23 |  |  | +23 |  | dB |
| Spectral Input Noise Voltage | 1 MHz to 200 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 3.5 |  |  | 3.5 |  | $\mathrm{nV} / \sqrt{\overline{\mathrm{Hz}}}$ |
| Spectral Input Noise Current | 1 MHz to 200 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 3.2 |  |  | 3.2 |  | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
| Average Equivalent Integrated Input Noise Voltage | 0.1 MHz to 200 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 49 |  |  | 49 |  | $\mu \mathrm{V}$ rms |
| TIME DOMAIN |  |  |  |  |  |  |  |  |  |  |
| Slew Rate | $\mathrm{V}_{\text {OUT }}=5 \mathrm{~V}$ Step | Full | IV | 1150 | 1500 |  | 1150 | 1500 |  | V/ $/ \mathrm{s}$ |
| Rise/Fall Time | $\mathrm{V}_{\text {OUT }}=0.5 \mathrm{~V}$ Step | $+25^{\circ} \mathrm{C}$ | V |  | 1.7 |  |  | 1.7 |  | ns |
|  | $\mathrm{V}_{\text {Out }}=5 \mathrm{~V}$ Step | Full | IV |  | 3.1 | 4.2 |  | 3.1 | 4.2 |  |
|  | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ Step | Full | IV |  | 3 | 15 |  | 3 | 15 | \% |
| Settling Time |  |  |  |  |  |  |  |  |  |  |
| To 0.1\% | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ Step | $+25^{\circ} \mathrm{C}$ | V |  | 8 |  |  | 8 |  |  |
| To 0.01\% | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ Step | Full | IV |  | 14 | 19 |  | 14 | 19 | ns |
| To 0.1\% ${ }^{3}$ | $\mathrm{V}_{\text {OUT }}=4 \mathrm{~V}$ Step | $+25^{\circ} \mathrm{C}$ | V |  | 10 |  |  | 10 |  | ns |
| To $0.01 \%^{3}$ | $\mathrm{V}_{\text {Out }}=4 \mathrm{~V}$ Step | $+25^{\circ} \mathrm{C}$ | V |  | 17 |  |  | 17 |  |  |
| Overdrive Recovery | $2 \times$ to $\pm 2 \mathrm{mV}$ | $+25^{\circ} \mathrm{C}$ | V |  | 150 |  |  | 150 |  | ns |
| Differential Gain (4.3 MHz) | $\mathrm{R}_{\mathrm{L}}=150 \Omega$ | $+25^{\circ} \mathrm{C}$ | V |  | 0.01 |  |  | 0.01 |  |  |
| Differential Phase (4.3 MHz) | $\mathrm{R}_{\mathrm{L}}=150 \Omega$ | $+25^{\circ} \mathrm{C}$ | V |  | <0.01 |  |  | <0.01 |  | degree |
| POWER SUPPLY REQUIREMENTS ${ }^{1}$ |  |  |  |  |  |  |  |  |  |  |
| Supply Voltage ( $\pm \mathrm{V}_{\mathrm{S}}$ ) |  | Full | IV | 3.0 | 5.0 | 5.5 | 3.0 | 5.0 | 5.5 | V |
| Quiescent Current |  |  |  |  |  |  |  |  |  |  |
| $+I_{s}$ | $+\mathrm{V}_{\mathrm{s}}=5 \mathrm{~V}$ | Full | VI |  | 23 | 29 |  | 23 | 29 | mA |
| -Is | $-\mathrm{V}_{\mathrm{s}}=-5 \mathrm{~V}$ | Full | VI |  | 23 | 29 |  | 23 | 29 | mA |
| Power Supply Rejection Ratio | $\Delta \mathrm{V}_{\text {S }}=0.5 \mathrm{~V}$ | $+25^{\circ} \mathrm{C}$ | I | 54 | 63 |  | 54 | 63 |  | dB |

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## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

Supply Voltages ( $\pm \mathrm{V}_{\mathrm{s}}$ ) ..... $\pm 6 \mathrm{~V}$
Common-Mode Input Voltage ..... $\pm V_{S}$
Voltage Swing $\times$ Bandwidth Product ..... $250 \mathrm{~V} \times \mathrm{MHz}$
Differential Input Voltage
90 mA
Continuous Output Current ${ }^{2}$
Operating Temperature Ranges
AN, AQ, AR
AN, AQ, AR ..... $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ..... $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
SQ $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature
Ceramic . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Plastic $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Junction Temperature
Ceramic ${ }^{3}$ ..... $+175^{\circ} \mathrm{C}$
Plastic ${ }^{3}$ ..... $+150^{\circ} \mathrm{C}$
Lead Soldering Temperature ( 1 minute) ${ }^{4}$ ..... $+220^{\circ} \mathrm{C}$
NOTES
${ }^{1}$ Absolute maximum ratings are limiting values to be applied individually, and beyond which the serviceability of the circuit may be impaired. Functional operability is not necessarily implied. Exposure to absolute maximum rating conditions for an extended period of time may affect device reliability.
${ }^{2}$ Output is short-circuit protected; for maximum reliability, 90 mA continuous current should not be exceeded.
${ }^{3}$ Typical thermal impedances (part soldered onto board; no air flow):
Ceramic DIP: $\theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=30^{\circ} \mathrm{C} / \mathrm{W}$
Plastic SOIC: $\theta_{\text {JA }}=125^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=45^{\circ} \mathrm{C} / \mathrm{W}$
Plastic DIP: $\theta_{\mathrm{JA}}=90^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=45^{\circ} \mathrm{C} / \mathrm{W}$
${ }^{4}$ Temperature shown is for surface mount devices, mounted by vapor phase soldering. Through-hole devices (Ceramic and Plastic DIPs) can be soldered at $+300^{\circ} \mathrm{C}$ for 10 seconds.

ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD9622AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | $\mathrm{N}-8$ |
| AD9622AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Cerdip | Q-8 |
| AD9622AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin SOIC | R-8 |
| AD9622SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Cerdip | Q-8 |

*For outline information see Package Information section.

## EXPLANATION OF TEST LEVELS

## Test Level

I - $100 \%$ production tested.
II $-100 \%$ production tested at $+25^{\circ} \mathrm{C}$, and sample tested at specified temperatures. AC testing of " A " grade devices done on sample basis.
III- Sample tested only.
IV- Parameter is guaranteed by design and characterization testing.
V - Parameter is a typical value only.
VI- All devices are $100 \%$ production tested at $+25^{\circ} \mathrm{C} .100 \%$ production tested at temperature extremes for extended temperature devices; sample tested at temperature extremes for commercial/industrial devices.


## THEORY OF OPERATION

The AD9622 is a wide bandwidth voltage feedback amplifier that is guaranteed for minimum gain stability of +2 . Since its open loop frequency response follows the conventional $6 \mathrm{~dB} /$ octave roll-off, its gain bandwidth product is basically constant. Increasing its closed-loop gain results in a corresponding decrease in small signal bandwidth. The AD9622 typically maintains a 60 degree unity loop gain phase margin with $R_{F} \cong$ $270 \Omega$. This high margin minimizes the effects of signal and noise peaking.

## Feedback Resistor Choice

At minimum stable gain ( +2 ), the AD9622 provides optimum dynamic performance with $R_{F}=270 \Omega$. When using this value and following the high speed layout guidelines, a shunt capacitor $\left(C_{F}\right)$ should not be required. This value for $R_{F}$ provides the best combination of wide bandwidth, low peaking, and distortion.

However, if improved gain flatness is desired, a shunt capacitor $\left(\mathrm{C}_{\mathrm{F}}\right)$ will provide extra phase margin. This reduces both overshoot and peaking with only a slight reduction of bandwidth.
As an example, if the amplifier exhibits (worst case) peaking of 1 dB with $\mathrm{R}_{\mathrm{G}} \| \mathrm{R}_{\mathrm{F}}=135 \Omega\left(\mathrm{~A}_{\mathrm{V}}=2\right)$, then using a $\mathrm{C}_{\mathrm{F}}$ of $\approx 1.5 \mathrm{pF}$ across $\mathrm{R}_{\mathrm{F}}$ will reduce this peaking to 0 dB . In addition, overshoot, noise, and settling time ( $0.01 \%$ ) will also improve. This comes at the expense of slightly decreased closedloop bandwidth due to the $\mathrm{R}_{\mathrm{F}} \times \mathrm{C}_{\mathrm{F}}$ time constant created.
If the equivalent input capacitance greatly exceeds 2 pF (due to source drive or long input traces to the amplifier), then added shunt capacitance ( $\mathrm{C}_{\mathrm{F}}$ ) will be necessary to maintain stability.
Likewise, if larger $R_{G} / R_{F}$ minimum-gain setting resistors are used, $\mathrm{C}_{\mathrm{F}}$ will be necessary. As a rule of thumb, if the product of $R_{F} \| \mathbb{R}_{G} \times C_{I} \leq 270 \times 10^{-12}$ seconds, then $C_{F}$ is not required (for maximum bandwidth applications) and the amplifier's phase margin will maintain about $60^{\circ}$.
For $R_{F} \| R_{G}>150 \Omega$, use a $C_{F}$ equal to $C_{I} \times R_{G} / R_{F}$. As the value of $R_{F} \| R_{G}$ increases, the bandwidth of the amplifier will begin to be controlled by the $R_{F} \times C_{F}$ time constant. Increasing $\mathrm{C}_{\mathrm{F}}$ much beyond these guidelines will also cause amplifier instability.

## Pulse Response

Unlike a traditional voltage feedback amplifier in which slew speed is usually dictated by its front end dc quiescent current and gain bandwidth product, the AD9622 provides "on demand" transconductance current that increases proportionally to the input "step" signal amplitude. This results in slew speeds ( $1500 \mathrm{~V} / \mu \mathrm{s}$ ) comparable to wideband current feedback designs. This, combined with relatively low input noise current ( 3.2 pA / $\sqrt{\mathrm{Hz}}$, gives the AD9622 the best attributes of both voltage and current feedback amplifiers.

## Bootstrap Capacitor ( $\mathrm{C}_{\mathrm{B}}$ )

In most applications, the $\mathrm{C}_{\mathrm{B}}$ capacitor should not be required. Under certain conditions, it can be used to further enhance settling time performance.

FEATURES
270 MHz Small Signal Bandwidth
190 MHz Large Signal BW (4 V p-p)
High Slew Rate: 2100 V/ $\mu \mathrm{s}$
Low Distortion: -64 dB @ 20 MHz
Fast Settling: 15 ns to 0.01
$2.6 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ Spectral Noise Density
$\pm 3$ V Supply Operation

## APPLICATIONS

ADC Input Driver
Differential Amplifiers
IF/RF Amplifiers
Pulse Amplifiers

## Professional Video

DAC Current-to-Voltage
Baseband and Video Communications
Active Filters/Integrators/Log Amps

## GENERAL DESCRIPTION

The AD9623 is one of a family of very high speed and wide bandwidth amplifiers utilizing a voltage feedback architecture. These amplifiers define a new level of performance for voltage feedback amplifiers, especially in the categories of large signal bandwidth, slew rate, settling, low distortion, and low noise.
Proprietary design architectures have resulted in an amplifier family that combines the most attractive attributes of both current feedback and voltage feedback amplifiers. The AD9623 exhibits extraordinarily accurate and fast pulse response characteristics ( 8 ns settling to $0.1 \%$ ) as well as extremely wide small and large signal bandwidth previously found only in current feedback amplifiers. When combined with balanced high impedance inputs and low input noise current more common to voltage feedback architectures, the AD9623 offers performance not previously available in a monolithic operational amplifier.

## CONNECTION DIAGRAM


\# OPTIONAL CAPACITOR CB CONNECTED HERE DECREASES SETTLING TIME (SEE TEXT).

Other members of the AD962X amplifier family are the AD9621 ( $\mathrm{G}=+1$ ), AD9622 ( $\mathrm{G}=+2$ ), and the AD9624 $(\mathrm{G}=+6)$. A separate data sheet is available from Analog Devices for each model. Each generic device has been designed for a different minimum stable gain setting, allowing users flexibility in optimizing system performance. Dynamic performance specifications such as slew rate, settling time, and distortion vary from model to model. The table below summarizes key performance attributes for the AD962X family and can be used as a selection guide.
The AD9623 is offered in industrial and military temperature ranges. Industrial versions are available in plastic DIP, SOIC, and cerdip; MIL versions are packaged in cerdips.

## PRODUCT HIGHLIGHTS

1. Wide Large Signal Bandwidth
2. High Slew Rate
3. Fast Settling
4. Low Distortion
5. Output Short-Circuit Protected
6. Low Intermodulation Distortion at High Frequencies
*Protected by U.S. Patent $\mathbf{5 , 1 5 0 , 0 7 4}$ and others pending.

| Parameter | AD9621 | AD9622 | AD9623 | AD9624 | Units |
| :--- | :--- | :--- | :--- | :--- | :--- |
| Minimum Stable Gain | +1 | +2 | +4 | +6 | V/V |
| Harmonic Distortion (20 MHz) | -52 | -66 | -64 | -66 | dB |
| Large Signal Bandwidth (4 V p-p) | 130 | 160 | 190 | 200 | MHz |
| SSBW (0.5 V p-p) | 350 | 220 | 270 | 300 | MHz |
| Slew Rate | 1200 | 1500 | 2100 | 2200 | $\mathrm{~V} / \mu \mathrm{s}$ |
| Rise/Fall Time (0.5 V Step) | 2.4 | 1.7 | 1.6 | 1.5 | ns |
| Settling Time (to 0.1\%/0.01\%) | $7 / 11$ | $8 / 14$ | $8 / 14$ | $8 / 14$ | ns |
| Input Noise (0.1 MHz-200 MHz) | 80 | 49 | 36 | 32 | $\mu \mathrm{~V} \mathrm{rms}$ |

This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

## AD9623-SPECIFICATIONS

DC ELECTRICAL CHARACTERIST|CS (Unless otherwise noted, $\pm V_{S}= \pm 5 V ; R_{\text {LoAD }}=100 \Omega ; A_{V}=+4 ; R_{F}=270 \Omega$ )

| Parameter | Conditions | Temp | Test Level | AD9623AN/AQ/AR |  |  | AD9623SQ |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max | Min | Typ | Max |  |
| DC SPECIFICATIONS ${ }^{1}$ |  |  |  |  |  |  |  |  |  |  |
| Input Offset Voltage |  | $+25^{\circ} \mathrm{C}$ | I | -8 | $\pm 2$ | +8 | -8 | $\pm 2$ | +8 | mV |
|  |  | Full | VI | $-10$ |  | +10 | -10 |  | +10 | mV |
| Input Bias Current |  | $+25^{\circ} \mathrm{C}$ | I |  | 6 | 12 |  | 6 | 12 | $\mu \mathrm{A}$ |
|  |  | Full | VI |  |  | 16 |  |  | 16 | $\mu \mathrm{A}$ |
| Bias Current TC |  | Full | V |  | 30 |  |  | 30 |  | $\mathrm{nA} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current |  | $+25^{\circ} \mathrm{C}$ | I | -2 | $\pm 0.3$ | +2 | -2 | $\pm 0.3$ | +2 | $\mu \mathrm{A}$ |
|  |  | Full | VI | -3 |  | +3 | -3 |  | +3 | $\mu \mathrm{A}$ |
| Offset Current TC |  | Full | V |  | 2.0 |  |  | 2.0 |  | $n A^{\circ} \mathrm{C}$ |
| Input Resistance |  | $+25^{\circ} \mathrm{C}$ | V |  | 600 |  |  | 600 |  | $\mathrm{k} \Omega$ |
| Input Capacitance |  | $+25^{\circ} \mathrm{C}$ | V |  | 1.2 |  |  | 1.2 |  | pF |
| Common-Mode Range |  | Full | VI | $\pm 3.0$ | $\pm 3.4$ |  | $\pm 3.0$ | $\pm 3.4$ |  | V |
| Common-Mode Rejection Ratio | $\Delta \mathrm{V}_{\mathrm{CM}}=1 \mathrm{~V}$ | $+25^{\circ} \mathrm{C}$ | I | 52 | 63 |  | 52 | 63 |  | dB |
| Open Loop Gain | $\mathrm{V}_{\text {OUT }}= \pm 2 \mathrm{~V}$ p-p | $+25^{\circ} \mathrm{C}$ | V |  | 69 |  |  | 69 |  | dB |
| Output Voltage Range |  | Full | VI | $\pm 3.0$ | $\pm 3.4$ |  | $\pm 3.0$ | $\pm 3.4$ |  | V |
| Output Current |  | Full | VI | 60 | 70 |  | 60 | 70 |  | mA |
| Output Resistance |  | $+25^{\circ} \mathrm{C}$ | V |  | 0.3 |  |  | 0.3 |  | $\Omega$ |
| FREQUENCY DOMAIN |  |  |  |  |  |  |  |  |  |  |
| Bandwidth ( -3 dB ) |  |  |  |  |  |  |  |  |  |  |
| Small Signal | $\mathrm{V}_{\text {OUT }}=0.4 \mathrm{~V}$ p-p | Full | II | 190 | 270 |  | 190 | 270 |  | MHz |
| Large Signal | $\mathrm{V}_{\text {OUT }}=4 \mathrm{~V}$ p-p | $+25^{\circ} \mathrm{C}$ | V |  | 190 |  |  | 190 |  | MHz |
| Amplitude of Peaking | Full Spectrum | Full | II |  | 0.1 | 1.2 |  | 0.1 | 1.2 | dB |
| Amplitude of Roll-off | DC to 100 MHz | Full | II |  | 0 | 0.7 |  | 0 | 0.7 | dB |
| Phase Nonlinearity | 0.3 MHz to 100 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 1.0 |  |  | 1.0 |  | Degree |
| 2nd Harmonic Distortion | 2 V p-p; 20 MHz | Full | II |  | -64 | -56 |  | -64 | -56 | dBc |
| 3rd Harmonic Distortion | $2 \mathrm{~V} \mathrm{p-p;} 20 \mathrm{MHz}$ | Full | II |  | -72 | -65 |  | -72 | -65 | dBc |
| Common-Mode Rejection Ratio | @ 20 MHz | $+25^{\circ} \mathrm{C}$ | V |  | +21 |  |  | +21 |  |  |
| Spectral Input Noise Voltage | 1 MHz to 200 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 2.6 |  |  | 2.6 |  | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| Spectral Input Noise Current | 1 MHz to 200 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 2.5 |  |  | 2.5 |  | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
| Average Equivalent Integrated Input Noise Voltage | 0.1 MHz to 200 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 36 |  |  | 36 |  | $\mu \mathrm{V}$ rms |
| TIME DOMAIN |  |  |  |  |  |  |  |  |  |  |
| Slew Rate | $\mathrm{V}_{\text {OUT }}=5 \mathrm{~V}$ Step | Full | IV | 1500 | 2100 |  | 1500 | 2100 |  | $\mathrm{V} / \mu \mathrm{s}$ |
| Rise/Fall Time | $\mathrm{V}_{\text {Out }}=0.5 \mathrm{~V}$ Step | $+25^{\circ} \mathrm{C}$ | V |  | 1.6 |  |  | 1.6 |  |  |
|  | $\mathrm{V}_{\text {OUT }}=5 \mathrm{~V}$ Step | Full | VI |  | 2.4 | 3.1 |  | 2.4 | 3.1 | ns |
| Overshoot | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ Step | Full | IV |  | 3 | 15 |  | 3 | 15 | \% |
| Settling Time |  |  |  |  |  |  |  |  |  |  |
| To 0.1\% | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ Step | $+25^{\circ} \mathrm{C}$ | V |  | 8 |  |  | 8 |  | ns |
| To 0.01\% | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ Step | Full | IV |  | 15 | 20 |  | 15 | 20 | ns |
| To 0.1\% ${ }^{2}$ | $\mathrm{V}_{\text {OUT }}=4 \mathrm{~V}$ Step | $+25^{\circ} \mathrm{C}$ | V |  | 9 |  |  | 9 |  | ns |
| To 0.01\% ${ }^{2}$ | $\mathrm{V}_{\text {OUT }}=4 \mathrm{~V}$ Step | $+25^{\circ} \mathrm{C}$ | V |  | 17 |  |  | 17 |  | ns |
| Overdrive Recovery | $2 \times$ to $\pm 2 \mathrm{mV}$ | $+25^{\circ} \mathrm{C}$ | V |  | 150 |  |  | 150 |  | ns |
| Differential Gain (4.3 MHz) | $\mathrm{R}_{\mathrm{L}}=150 \Omega$ | $+25^{\circ} \mathrm{C}$ | V |  | 0.01 |  |  | 0.01 |  |  |
| Differential Phase ( 4.3 MHz ) | $\mathrm{R}_{\mathrm{L}}=150 \Omega$ | $+25^{\circ} \mathrm{C}$ | V |  | $<0.01$ |  |  | <0.01 |  | Degree |
| POWER SUPPLY REQUIREMENTS ${ }^{1}$ |  |  |  |  |  |  |  |  |  |  |
| Supply Voltage ( $\pm \mathrm{V}_{\mathrm{S}}$ ) |  | Full | IV | 3.0 | 5.0 | 5.5 | 3.0 | 5.0 | 5.5 | V |
| Quiescent Current |  |  |  |  |  |  |  |  |  |  |
| $+\mathrm{I}_{\text {S }}$ | $+\mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}$ | Full | VI |  | 23 | 29 |  | 23 | 29 | mA |
| $-\mathrm{I}_{5}$ | $-\mathrm{V}_{\mathrm{s}}=-5 \mathrm{~V}$ | Full | VI |  | 23 | 29 |  | 23 | 29 | mA |
| Power Supply Rejection Ratio | $\Delta \mathrm{V}_{\mathrm{S}}=1 \mathrm{~V}$ | $+25^{\circ} \mathrm{C}$ | I | 60 | 71 |  | 60 | 71 |  | dB |

[^168]
## ABSOLUTE MAXIMUM RATINGS ${ }^{\mathbf{1}}$

| Supply Voltages ( $\pm \mathrm{V}_{\text {S }}$ ) . . . . . . . . . . . . . . . . . . . . . . $\pm 6$ V |  |
| :---: | :---: |
| Common-Mode Input Voltage | $\pm \mathrm{V}_{\text {S }}$ |
| Differential Input Voltage . . . . . . . . . . . . . . . . . . . 6 V |  |
| Continuous Output Current ${ }^{2}$. . . . . . . . . . . . . . . . . 90 mA |  |
| Operating Temperature Ranges |  |
| AN, AQ, AR . . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |
| SQ . . . . . . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  |
| Storage Temperature |  |
| Ceramic . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |  |
| Plastic . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  |
| Junction Temperature |  |
| Ceramic ${ }^{3}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . $+1755^{\circ} \mathrm{C}$ |  |
| Plastic ${ }^{3}$ | $+150^{\circ} \mathrm{C}$ |

Lead Soldering Temperature ( 1 minute) ${ }^{4}$. . . . . . . . . . $+220^{\circ} \mathrm{C}$
NOTES
${ }^{1}$ Absolute maximum ratings are limiting values to be applied individually, and beyond which the serviceability of the circuit may be impaired. Functional operability is not necessarily implied. Exposure to absolute maximum rating conditions for an extended period of time may affect device reliability.
${ }^{2}$ Output is short-circuit protected; for maximum reliability, 90 mA continuous current should not be exceeded.
${ }^{3}$ Typical thermal impedances (part soldered onto board; no air flow):
Ceramic DIP: $\theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=30^{\circ} \mathrm{C} / \mathrm{W}$
Plastic SOIC: $\theta_{\mathrm{JA}}=125^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=45^{\circ} \mathrm{C} / \mathrm{W}$
Plastic DIP: $\theta_{\mathrm{JA}}=90^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=45^{\circ} \mathrm{C} / \mathrm{W}$
${ }^{4}$ Temperature shown is for surface mount devices, mounted by vapor phase soldering. Throughhole devices (Ceramic and Plastic DIPs) can be soldered at $+300^{\circ} \mathrm{C}$ for 10 seconds.

## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD9623AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | $\mathrm{N}-8$ |
| AD9623AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Cerdip | Q-8 |
| AD9623AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin SOIC | R-8 |
| AD9623SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Cerdip | Q-8 |

*For outline information see Package Information section.

## EXPLANATION OF TEST LEVELS

## Test Level

I - 100\% production tested.
II $-100 \%$ production tested at $+25^{\circ} \mathrm{C}$, and sample tested at specified temperatures. AC testing of A-grade devices done on sample basis.
III- Sample tested only.
IV- Parameter is guaranteed by design and characterization testing.
V - Parameter is a typical value only.
VI- All devices are $100 \%$ production tested at $+25^{\circ} \mathrm{C} .100 \%$ production tested at temperature extremes for extended temperature devices; sample tested at temperature extremes for commercial/industrial devices.


## THEORY OF OPERATION

The AD9623 is a wide bandwidth voltage feedback amplifier that is guaranteed for minimum gain stability of +4 . Since its open-loop frequency response follows the conventional $6 \mathrm{~dB} /$ octave roll-off, its gain bandwidth product is basically constant. Increasing its closed-loop gain results in a corresponding decrease in small signal bandwidth. The AD9623 typically maintains a 60 degree unity loop gain phase margin. This high margin minimizes the effects of signal and noise peaking.

## Feedback Resistor Choice

At minimum stable gain ( +4 ), the AD9623 provides optimum dynamic performance with $R_{F} \cong 390 \Omega$. When using this value and following the high speed layout guidelines, a shunt capacitor ( $\mathrm{C}_{\mathrm{F}}$ ) should not be required. This value $\mathrm{R}_{\mathrm{F}}$ provides the best combination of wide bandwidth, low peaking, and distortion.

However, if improved gain flatness is desired, a shunt capacitor $\left(\mathrm{C}_{\mathrm{F}}\right)$ will provide extra phase margin. This reduces both overshoot and peaking with only a slight reduction of bandwidth. See Figure 1.
As an example, if the amplifier exhibits (worst case) peaking of 1 dB with $\mathrm{R}_{\mathrm{G}} \| \mathrm{R}_{\mathrm{F}}=98 \Omega\left(\mathrm{~A}_{\mathrm{V}}=4\right)$, then using an effective $\mathrm{C}_{\mathrm{F}}$ of $\approx 0.5-1 \mathrm{pF}$ across $\mathrm{R}_{\mathrm{F}}$ will reduce this peaking to 0 dB . In addition, overshoot, noise, and settling time ( $0.01 \%$ ) will also improve. This comes at the expense of slightly decreased closedloop bandwidth due to the $\mathrm{R}_{\mathrm{F}} \times \mathrm{C}_{\mathrm{F}}$ time constant created.
If total input capacitance greatly exceeds 3 pF (due to source drive or long input traces to the amplifier), then added shunt capacitance ( $\mathrm{C}_{\mathrm{F}}$ ) will be necessary to maintain stability for minimum gain.
Likewise, if larger $R_{G} / R_{F}$ minimum-gain setting resistors are used, $\mathrm{C}_{\mathrm{F}}$ will be necessary. As a rule of thumb, if the product of $R_{F} \| R_{G} \times C_{I} \leq 300 \times 10^{-12}$ seconds, then $C_{F}$ is not required (for maximum bandwidth at minimum gain) and the amplifier's phase margin will maintain about $60^{\circ}$.
For $R_{F} \| R_{G}>150 \Omega$, use a $C_{F}$ equal to $C_{I} \times R_{G} / R_{F}$. For $C_{I}$ (total) @ 2 pF , requires $\mathrm{C}_{\mathrm{F}}$ to be 0.5 pF . This can be achieved by two 1 pF capacitors in series, or by using a resistor divider network at the amplifier's output in conjunction with a larger capacitor. Increasing $C_{F}$ much beyond these guidelines will also cause amplifier instability.

## Pulse Response

Unlike a traditional voltage feedback amplifier in which slew speed is usually dictated by its front end dc quiescent current and gain bandwidth product, the AD9623 provides "on demand" transconductance current that increases proportionally to the input "step" signal amplitude. This results in slew speeds ( $2100 \mathrm{~V} / \mu \mathrm{s}$ ) comparable to wideband current feedback designs. This, combined with relatively low input noise current ( $2.5 \mathrm{pA} /$ $\sqrt{\mathrm{Hz}}$ ), gives the AD9623 the best attributes of both voltage and current feedback amplifiers.
Bootstrap Capacitor ( $\mathrm{C}_{\mathrm{B}}$ )
In most applications, the $\mathrm{C}_{\mathrm{B}}$ capacitor will not be required. Under certain conditions, it can be used to further enhance settling time performance.

## FEATURES

300 MHz Small Signal Bandwidth
200 MHz Large Signal BW (4 V p-p)
High Slew Rate: 2200 V/ $\mu \mathrm{s}$
Low Distortion: -60 dB @ 20 MHz
Fast Settling: 15 ns to $0.01 \%$
2.2 nV/ $\sqrt{\mathrm{Hz}}$ Spectral Noise Density
$\pm 3$ V Supply Operation

## APPLICATIONS

ADC Input Driver
Differential Amplifiers
IF/RF Amplifiers
Pulse Amplifiers
Professional Video
DAC Current-to-Voltage
Baseband and Video Communications
Active Filters/Integrators/Log Amps

## GENERAL DESCRIPTION

The AD9624 is one of a family of very high speed and wide bandwidth amplifiers utilizing a voltage feedback architecture. These amplifiers define a new level of performance for voltage feedback amplifiers, especially in the categories of large signal bandwidth, slew rate, settling, low distortion, and low noise.
Proprietary design architectures have resulted in an amplifier family that combines the most attractive attributes of both current feedback and voltage feedback amplifiers. The AD9624 exhibits extraordinarily accurate and fast pulse response characteristics ( 8 ns settling to $0.1 \%$ ) as well as extremely wide small and large signal bandwidth previously found only in current feedback amplifiers. When combined with balanced high impedance inputs and low input noise current more common to voltage feedback architectures, the AD9624 offers performance not previously available in a monolithic operational amplifier.

CONNECTION DIAGRAM

\# OPTIONALCAPACITOR CB CONNECTED HERE DECREASES SETTLING TIME (SEE TEXT).

Other members of the AD962X amplifier family are the AD9621 ( $\mathrm{G}=+1$ ), AD9622 ( $\mathrm{G}=+2$ ), and the AD9623 ( $\mathrm{G}=$ $+4)$. A separate data sheet is available from Analog Devices for each model. Each generic device has been designed for a different minimum stable gain setting, allowing users flexibility in optimizing system performance. Dynamic performance specifications such as slew rate, settling time, and distortion vary from model to model. The table below summarizes key performance attributes for the AD962X family and can be used as a selection guide.
The AD9624 is offered in industrial and military temperature ranges. Industrial versions are available in plastic DIP, SOIC, and cerdip; MIL versions are packaged in cerdips.

## PRODUCT HIGHLIGHTS

1. Wide Large Signal Bandwidth
2. High Slew Rate
3. Fast Settling
4. Low Distortion
5. Output Short-Circuit Protected
6. Low Intermodulation Distortion at High Frequencies
*Protected by U.S. Patent $\mathbf{5 , 1 5 0 , 0 7 4}$ and others pending.

| Parameter | AD9621 | AD9622 | AD9623 | AD9624 | Units |
| :--- | :--- | :--- | :--- | :--- | :--- |
| Minimum Stable Gain | +1 | +2 | +4 | +6 | V/V |
| Harmonic Distortion (20 MHz) | -52 | -66 | -64 | -66 | dB |
| Large Signal Bandwidth (4 V p-p) | 130 | 160 | 190 | 200 | MHz |
| SSBW (0.5 V p-p) | 350 | 220 | 270 | 300 | MHz |
| Slew Rate | 1200 | 1500 | 2100 | 2200 | $\mathrm{~V} / \mu \mathrm{s}$ |
| Rise/Fall Time (0.5 V Step) | 2.4 | 1.7 | 1.6 | 1.5 | ns |
| Settling Time (to $0.1 \% / 0.01 \%)$ | $7 / 11$ | $8 / 14$ | $8 / 14$ | $8 / 14$ | ns |
| Input Noise ( $0.1 \mathrm{MHz}-200 \mathrm{MHz})$ | 80 | 49 | 36 | 32 | $\mu \mathrm{rms}$ |

This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

DC ELECTRICAL CHARACTERISTICS (Uness otherwise noted, $\pm V_{s}= \pm 5 v_{;} R_{\text {Laup }}=100 \Omega_{;} A_{v}=+8 ; R_{F}=510 \Omega$

| Parameter | Conditions | Temp | Test Level | AD9624AN/AQ/AR |  |  | AD9624SQ |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max | Min | Typ | Max |  |
| DC SPECIFICATIONS ${ }^{1}$ |  |  |  |  |  |  |  |  |  |  |
| Input Offset Voltage |  | $+25^{\circ} \mathrm{C}$ | I | -8 | $\pm 2$ | +8 | -8 | $\pm 2$ | +8 | mV |
|  |  | Full | VI | -10 |  | +10 | -10 |  | +10 | mV |
| Input Bias Current |  | $+25^{\circ} \mathrm{C}$ | V |  | 7 | 12 |  | 7 | 12 | $\mu \mathrm{A}$ |
|  |  | Full | VI |  |  | 16 |  |  | 16 | $\mu \mathrm{A}$ |
| Bias Current TC |  | Full | V |  | 35 |  |  | 35 |  | $\mathrm{nA} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current |  | $+25^{\circ} \mathrm{C}$ | I | -2 | $\pm 0.3$ | +2 | -2 | $\pm 0.3$ | +2 | $\mu \mathrm{A}$ |
|  |  | Full | VI | -3 |  | +3 | -3 |  | +3 | $\mu \mathrm{A}$ |
| Offset Current TC |  | Full | V |  | 2.5 |  |  | 2.5 |  | $\mathrm{nA} /{ }^{\circ} \mathrm{C}$ |
| Input Resistance |  | $+25^{\circ} \mathrm{C}$ | V |  | 500 |  |  | 500 |  | $\mathrm{k} \Omega$ |
| Input Capacitance |  | $+25^{\circ} \mathrm{C}$ | V |  | 1.2 |  |  | 1.2 |  | pF |
| Common-Mode Range |  | Full | VI | $\pm 3.0$ | $\pm 3.4$ |  | $\pm 3.0$ | $\pm 3.4$ |  | V |
| Common-Mode Rejection Ratio | $\Delta \mathrm{V}_{\mathrm{CM}}=1 \mathrm{~V}$ | $+25^{\circ} \mathrm{C}$ | I | 52 | 63 |  | 52 | 63 |  | dB |
| Open-Loop Gain | $\mathrm{V}_{\text {OUT }}= \pm 2 \mathrm{~V}$ p-p | $+25^{\circ} \mathrm{C}$ | V |  | 74 |  |  | 74 |  | dB |
| Output Voltage Range |  | Full | VI | $\pm 3.0$ | $\pm 3.4$ |  | $\pm 3.0$ | $\pm 3.4$ |  | V |
| Output Current |  | Full | II | 60 | 70 |  | 60 | $70$ |  | $\mathrm{mA}$ |
| Output Resistance |  | $+25^{\circ} \mathrm{C}$ | V |  | 0.3 |  |  | 0.3 |  | $\Omega$ |
| FREQUENCY DOMAIN |  |  |  |  |  |  |  |  |  |  |
| Small Signal Bandwidth |  |  |  |  |  |  |  |  |  |  |
| $A_{v}=6$ | $\mathrm{V}_{\text {OUT }}=0.4 \mathrm{~V}$ p-p | Full | IV | 200 | 300 |  | 200 | 300 |  | MHz |
| $A_{V}=8$ | $\mathrm{V}_{\text {OUT }}=0.4 \mathrm{~V} \mathrm{p-p}$ | Full | II | 130 | 190 |  | 130 | 190 |  | MHz |
| Large Signal Bandwidth | $\mathrm{V}_{\text {Out }}=4 \mathrm{~V}$ p-p | $+25^{\circ} \mathrm{C}$ | V |  | 170 |  |  | 170 |  | MHz |
| Amplitude of Peaking | Full Spectrum | Full | II |  | 0 | 0.4 |  | 0 | 0.4 | dB |
| Amplitude of Peaking ( $\mathrm{A}_{\mathrm{V}}=6$ ) | Full Spectrum | $+25^{\circ} \mathrm{C}$ | IV |  | 0.2 | 1.2 |  | 0.2 | 1.2 | dB |
| Amplitude of Roll-off | DC to 100 MHz | Full | II |  | 0.6 | 1.6 |  | 0.6 | 1.6 | dB |
| Phase Nonlinearity | 0.3 MHz to 100 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 0.7 |  |  | 0.7 |  | Degree |
| 2nd Harmonic Distortion | 2 V p-p; 20 MHz | Full | II |  | -60 | -52 |  | -60 | -52 | dBc |
| 3rd Harmonic Distortion | 2 V p-p; 20 MHz | Full | II |  | -72 | -64 |  | -72 | -64 | dBc |
| Common-Mode Rejection Ratio | @ 20 MHz | $+25^{\circ} \mathrm{C}$ | V |  | +30 |  |  | +30 |  | dB |
| Spectral Input Noise Voltage | 1 MHz to 200 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 2.2 |  |  | 2.2 |  | $\mathrm{nV} / \sqrt{\overline{\mathrm{Hz}}}$ |
| Spectral Input Noise Current | 1 MHz to 200 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 2.5 |  |  | 2.5 |  | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
| Average Equivalent Integrated Input Noise Voltage | 0.1 MHz to 200 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 32 |  |  | 32 |  | $\mu \mathrm{V}$ rms |
| TIME DOMAIN |  |  |  |  |  |  |  |  |  |  |
| Slew Rate | $\mathrm{V}_{\text {OUT }}=5 \mathrm{~V}$ Step | Full | IV | 1400 | 2000 |  | 1400 | 2000 |  | V/ $/ \mathrm{s}$ |
| Rise/Fall Time | $\mathrm{V}_{\text {OUT }}=0.5 \mathrm{~V}$ Step | $+25^{\circ} \mathrm{C}$ | V |  | 1.8 |  |  | 1.8 |  |  |
|  | $\mathrm{V}_{\text {OUT }}=5 \mathrm{~V}$ Step | Full | IV |  | 2.6 | 3.2 |  | 2.6 | 3.2 |  |
| Overshoot | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ Step | Full | IV |  | 0 | 7 |  | 0 | 7 | \% |
| Settling Time |  |  |  |  |  |  |  |  |  |  |
| To 0.1\% | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ Step | $+25^{\circ} \mathrm{C}$ | V |  | 8 |  |  | 8 |  | ns |
| To 0.01\% | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ Step | Full | IV |  |  | 20 |  | 15 | 20 | ns |
| To 0.1\% ${ }^{2}$ | $\mathrm{V}_{\text {OUT }}=4 \mathrm{~V}$ Step | $+25^{\circ} \mathrm{C}$ | V |  | 9 |  |  | 9 |  | ns |
| To 0.01\% ${ }^{2}$ | $\mathrm{V}_{\text {OUT }}=4 \mathrm{~V}$ Step | $+25^{\circ} \mathrm{C}$ | V |  | 17 |  |  | 17 |  | ns |
| Overdrive Recovery | $2 \times$ to $\pm 2 \mathrm{mV}$ | $+25^{\circ} \mathrm{C}$ | V |  | 130 |  |  | 130 |  | ns |
| Differential Gain (4.3 MHz) | $\mathrm{R}_{\mathrm{L}}=150 \Omega$ | $+25^{\circ} \mathrm{C}$ | V |  | 0.015 |  |  | 0.015 |  | \% |
| Differential Phase (4.3 MHz) | $\mathrm{R}_{\mathrm{L}}=150 \Omega$ | $+25^{\circ} \mathrm{C}$ | V |  | <0.01 |  |  | <0.01 |  | Degree |
| POWER SUPPLY REQUIREMENTS ${ }^{1}$ |  |  |  |  |  |  |  |  |  |  |
| Supply Voltage ( $\pm \mathrm{V}_{\mathrm{S}}$ ) |  | Full | IV | 3.0 | 5.0 | 5.5 | 3.0 | 5.0 | 5.5 | V |
| Quiescent Current |  |  |  |  |  |  |  |  |  |  |
| $+\mathrm{I}_{\mathrm{s}}$ | $+\mathrm{V}_{\mathrm{s}}=5 \mathrm{~V}$ | Full | VI |  | 23 | 29 |  | 23 | 29 | mA |
| $-I_{s}$ | $-\mathrm{V}_{\mathrm{s}}=-5 \mathrm{~V}$ | Full | VI |  | 23 | 29 |  | 23 | 29 | mA |
| Power Supply Rejection Ratio | $\Delta \mathrm{V}_{\mathrm{S}}=1 \mathrm{~V}$ | $+25^{\circ} \mathrm{C}$ | I | 60 | 70 |  | 60 | 70 |  | dB |

[^169]
## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$ <br> Supply Voltages ( $\pm \mathrm{V}_{\mathrm{s}}$ ) . . . . . . . . . . . . . . . . . . . . . . . $\pm 6$ V

Common-Mode Input Voltage . . . . . . . . . . . . . . . . . . . $\pm \mathrm{V}_{\text {S }}$
Differential Input Voltage . . . . . . . . . . . . . . . . . . . . . . 6 V
Continuous Output Current ${ }^{2}$. . . . . . . . . . . . . . . . . . 90 mA
Operating Temperature Ranges
AN, AQ, AR
$-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
SQ . . . . . . . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$

Storage Temperature
Ceramic . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Plastic . . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Junction Temperature
Ceramic ${ }^{3}$
$+175^{\circ} \mathrm{C}$
Plastic ${ }^{3}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $+150^{\circ} \mathrm{C}$
Lead Soldering Temperature ( 1 minute $)^{4} \ldots \ldots . . . . .+220^{\circ} \mathrm{C}$
NOTES
${ }^{1}$ Absolute maximum ratings are limiting values to be applied individually, and beyond which the serviceability of the circuit may be impaired. Functional operability is not necessarily implied. Exposure to absolute maximum rating conditions for an extended period of time may affect device reliability.
${ }^{2}$ Output is short-circuit protected; for maximum reliability, 90 mA continuous current should not be exceeded.
${ }^{3}$ Typical thermal impedances (part soldered onto board; no air flow):
Ceramic DIP: $\theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=30^{\circ} \mathrm{C} / \mathrm{W}$
Plastic SOIC: $\theta_{\mathrm{JA}}=125^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=45^{\circ} \mathrm{C} / \mathrm{W}$
Plastic DIP: $\theta_{\mathrm{JA}}=90^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=45^{\circ} \mathrm{C} / \mathrm{W}$
${ }^{4}$ Temperature shown is for surface mount devices, mounted by vapor phase soldering. Through-hole devices (ceramic and plastic DIPs) can be soldered at $+300^{\circ} \mathrm{C}$ for 10 seconds.

## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD9624AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | $\mathrm{N}-8$ |
| AD9624AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Cerdip | $\mathrm{Q}-8$ |
| AD9624AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin SOIC | $\mathrm{R}-8$ |
| AD9624SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Cerdip | $\mathrm{Q}-8$ |

## *For outline information see Package Information section.

## EXPLANATION OF TEST LEVELS

## Test Level

I - $100 \%$ production tested.
II $-100 \%$ production tested at $+25^{\circ} \mathrm{C}$, and sample tested at specified temperatures. AC testing of A-grade devices done on sample basis.
III- Sample tested only.
IV- Parameter is guaranteed by design and characterization testing.
V - Parameter is a typical value only.
VI- All devices are $100 \%$ production tested at $+25^{\circ} \mathrm{C} .100 \%$ production tested at temperature extremes for extended temperature devices; sample tested at temperature extremes for commercial/industrial devices.


## THEORY OF OPERATION

The AD9624 is a wide bandwidth voltage feedback amplifier that is guaranteed for minimum gain stability of +6 . Since its open loop frequency response follows the conventional $6 \mathrm{~dB} /$ octave roll-off, its gain bandwidth product is basically constant. Increasing its closed-loop gain results in a corresponding decrease in small signal bandwidth. The AD9624 typically maintains a 60 degree unity loop gain phase margin with $R_{F} \cong$ $510 \Omega$. This high margin minimizes the effects of signal and noise peaking.

## Feedback Resistor Choice

At minimum stable gain ( +6 ), the AD9624 provides optimum dynamic performance with $\mathrm{R}_{\mathrm{F}}=510 \Omega$. When using this value and following the high speed layout guidelines, a shunt capacitor $\left(C_{F}\right)$ should not be required. This value for $R_{F}$ provides the best combination of wide bandwidth, low peaking, and distortion.
However, if improved gain flatness is desired, a shunt capacitor $\left(C_{F}\right)$ will provide extra phase margin. This reduces both overshoot and peaking with only a slight reduction of bandwidth.
As an example, if the amplifier exhibits (worst case) peaking of 1.2 dB with $\mathrm{R}_{\mathrm{G}} \| \mathrm{R}_{\mathrm{F}}=85 \Omega\left(\mathrm{~A}_{\mathrm{V}}=6\right)$, then using a $\mathrm{C}_{\mathrm{F}}$ of $\approx 0.5 \mathrm{pF}$ (two 1 pF capacitors in series) across $\mathrm{R}_{\mathrm{F}}$ will reduce this peaking to 0 dB . In addition, overshoot, noise, and settling time ( $<0.01 \%$ ) will also improve. This comes at the expense of slightly decreased closed-loop bandwidth due to the $\mathrm{R}_{\mathrm{F}} \times \mathrm{C}_{\mathrm{F}}$ time constant created.
If the equivalent input capacitance greatly exceeds 4 pF (due to source drive or long input traces to the amplifier), then added shunt capacitance $\left(C_{F}\right)$ will be necessary to maintain stability at minimum gain.
As a rule of thumb, if the product of $\mathbf{R}_{\mathrm{F}} \| \mathrm{R}_{\mathrm{G}} \times \mathrm{C}_{\mathrm{I}} \leq 300 \times$ $10^{-12}$ seconds, then $\mathrm{C}_{\mathrm{F}}$ is not required (for maximum bandwidth applications) and the amplifier's phase margin will maintain about $60^{\circ}$. Generally, this should be the case.

## Pulse Response

Unlike a traditional voltage feedback amplifier in which slew speed is usually dictated by its front end dc quiescent current and gain bandwidth product, the AD9624 provides "on demand" transconductance current that increases proportionally to the input "step" signal amplitude. This results in slew speeds ( $2000 \mathrm{~V} / \mu \mathrm{s}$ ) comparable to wideband current feedback designs. This, combined with relatively low input noise current $(2.5 \mathrm{pA}$ / $\sqrt{\mathrm{Hz}}$ ), gives the AD9624 the best attributes of both voltage and current feedback amplifiers.

Low Distortion, 750 MHz Closed-Loop Buffer Amp

AD9630*

## FEATURES

Excellent Gain Accuracy: 0.99 V/V
Wide Bandwidth: 750 MHz
Slew Rate: 1200 V/ $\mu \mathrm{s}$
Low Distortion
-65 dBc@ 20 MHz
$-80 \mathrm{dBc} @ 4.3 \mathrm{MHz}$
Settling Time
6 ns to 0.1\%
8 ns to 0.02\%
Low Noise: 2.4 nV/ $\sqrt{\mathrm{Hz}}$
Improved Source for CLC-110

## APPLICATIONS

IF/Communications<br>Impedance Transformations<br>Drives Flash ADCs<br>Line Driving

## PIN CONFIGURATION



NOTE: FOR BEST SETTLING TIME PERFORMANCE USE OPTIONAL POWER SUPPLIES. ALL SPECIFICATIONS ARE BASED ON USING SINGLE $\pm \mathbf{V}_{S}$ CONNECTIONS EXCEPT FOR SETTLING TIME TO $0.02 \%$ AND SMALL SIGNAL S21. CONSULT THE FACTORY FOR VERSIONS WITH OPTIONAL POWER SUPPLY PINS DISCONNECTED INTERNAL TO THE PACKAGE.

## General Description

The AD9630 is a monolithic buffer amplifier that utilizes innovative (patent pending) closed-loop design techniques to achieve exceptional gain accuracy, wide bandwidth, and low distortion. Slew rate limiting has been overcome as indicated by the $1200 \mathrm{~V} / \mu \mathrm{s}$ slew rate; this improvement allows the user greater flexibility in wideband and pulse applications. The second harmonic distortion terms for an analog input tone of 4.3 MHz and 20 MHz are -80 dBc and -66 dBc , respectively. Clearly, the AD9630 establishes a new standard by combining in one part outstanding dc and dynamic performance.
The large signal bandwidth, low distortion over frequency, and drive capabilities of the AD9630 make the buffer an ideal flash ADC driver. The AD9630 provides better signal fidelity than many of the flash ADCs that it has been designed to drive.

Other applications which require increased current drive at unity voltage gain such as cable driving benefit from the AD9630's performance.

The AD9630 is available in Plastic DIP (N), Ceramic DIP (Q), and SOIC (R). Consult with the factory concerning availability of MIL-STD-883 parts. Die are dc tested at $+25^{\circ} \mathrm{C}$.

## DIE LAYOUT

Die Dimensions $60 \times 50 \times 15$ mils


[^170]This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

## AD9630-SPECIFICATIONS

ABSOLUTE MAXIMUM RATINGS ${ }^{1}$
Supply Voltages ( $\pm \mathrm{V}_{\mathrm{S}}$ ) . . . . . . . . . . . . . . . . . . . . . . . $\pm 7$ V
Continuous Output Current ${ }^{2}$. . . . . . . . . . . . . . . . . . 70 mA
Temperature Range over Which Specifications Apply
AD9630AN/AR/AQ . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$

Lead Soldering Temperature ( 10 sec ) . . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Storage Temperature
AD9630AN/AR/AQ . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ Junction Temperature ${ }^{3}$

AD9630AN/AR/AQ . . . . . . . . . . . . . . . . . . . . . . $+150^{\circ} \mathrm{C}$

ELECTRICAL CHARACTERISTICS (unless otherwise noted, $\pm v_{s}= \pm 5 v_{;} R_{1 / W}=50 \Omega ; R_{\text {LOAO }}=100 \Omega$ )

| Parameter | Conditions | Temp | Test Level | AD9630AN/AR/AQ |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max |  |
| DC SPECIFICATIONS |  |  |  |  |  |  |  |
| Output Offset Voltage |  | $+25^{\circ} \mathrm{C}$ | I | -8 | $\pm 3$ | +8 | mV |
| Offset Voltage TC |  | Full | IV | -40 | $\pm 8$ | +40 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Bias Current |  | $+25^{\circ} \mathrm{C}$ | I | -25 | $\pm 2$ | +25 | $\mu \mathrm{A}$ |
| Bias Current TC |  | Full | IV | -100 | $\pm 20$ | $+100$ | nA/ ${ }^{\circ} \mathrm{C}$ |
| Input Resistance |  | +25 to $\mathrm{T}_{\text {max }}$ | II | 300 | 450 |  | k $\Omega$ |
| Input Resistance |  | $\mathrm{T}_{\text {min }}$ | VI | 150 | 250 |  | k $\Omega$ |
| Input Capacitance |  | $+25^{\circ} \mathrm{C}$ | V |  | 1.0 |  | pF |
| Gain | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ p-p | +25 to $\mathrm{T}_{\text {max }}$ | II | 0.983 | 0.990 |  | V/V |
| Gain | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ p-p | $\mathrm{T}_{\text {min }}$ | VI | 0.980 | 0.985 |  | V/V |
| Output Voltage Range |  | Full | VI | +3.2 | $\pm 3.6$ | -3.2 |  |
| Output Current ( $50 \Omega$ Load) |  | +25 to $\mathrm{T}_{\text {max }}$ | II | 50 |  |  | mA |
| Output Current ( $50 \Omega$ Load) |  | $\mathrm{T}_{\text {min }}$ | VI | 40 |  |  | mA |
| Output Impedance | At dc | $+25^{\circ} \mathrm{C}$ | V |  | 0.6 |  | $\Omega$ |
| PSRR | $\Delta \mathrm{V}_{\mathrm{S}}= \pm 5 \%$ | Full | VI | 44 | 55 |  | dB |
| DC Nonlinearity | $\pm 2 \mathrm{~V}$ Full Scale | $+25^{\circ} \mathrm{C}$ | V |  | 0.03 |  | \% |
| FREQUENCY DOMAIN |  |  |  |  |  |  |  |
| Bandwidth ( -3 dB ) |  |  |  |  |  |  |  |
| Small Signal | $\mathrm{V}_{\mathrm{o}} \leq 0.7 \mathrm{~V}$ p-p | $\mathrm{T}_{\text {min }}$ to 25 | II | 400 | 750 |  | MHz |
| Small Signal | $\mathrm{V}_{\mathrm{o}} \leq 0.7 \mathrm{~V} \mathrm{p-p}$ | $\mathrm{T}_{\text {max }}$ | II | 330 | 550 |  | MHz |
| Large Signal | $\mathrm{V}_{\mathrm{O}}=5 \mathrm{~V} \mathrm{p}-\mathrm{p}$ | $\mathrm{T}_{\text {min }}$ to 25 | V |  | 120 |  | MHz |
| Large Signal | $\mathrm{V}_{\mathrm{O}}=5 \mathrm{~V} \mathrm{p}-\mathrm{p}$ | $\mathrm{T}_{\text {max }}$ | V |  | 105 |  | MHz |
| Output Peaking | $\leq 200 \mathrm{MHz}$ | Full | II |  | 0.4 | 1.2 | dB |
| Output Rolloff | $\leq 200 \mathrm{MHz}$ | Full | II |  | 0 | 0.3 | dB |
| Group Delay | dc to 150 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 0.7 |  | ns |
| Linear Phase Deviation | dc to 150 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 0.7 |  | Degrees |
| 2nd Harmonic Distortion | 2 V p-p; 4.3 MHz | Full | IV |  | -80 | -73 | dBc |
|  | 2 V p-p; 20 MHz | Full | IV |  | -66 | -58 | dBc |
|  | 2 V p-p; 50 MHz | Full | II |  | -52 | -43 | dBc |
| 3rd Harmonic Distortion | 2 V p-p; 4.3 MHz | Full | IV |  | -86 | -79 | dBc |
|  | 2 V p-p; 20 MHz |  | IV |  | -75 | -68 |  |
|  | 2 V p-p; 50 MHz | $\mathrm{T}_{\text {min }}$ to +25 | II |  | -47 | -41 | dBc |
|  | 2 V p-p; 50 MHz | $\mathrm{T}_{\text {max }}$ | II |  | -46 | -40 | dBc |
| Spectral Input Noise Voltage | 10 MHz | + $25^{\circ} \mathrm{C}$ | V |  | 2.4 |  | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| Integrated Output Noise | $100 \mathrm{kHz}-200 \mathrm{MHz}$ | $+25^{\circ} \mathrm{C}$ | V |  | 32 |  | $\mu \mathrm{V}$ |
| TIME DOMAIN |  |  |  |  |  |  |  |
| Slew Rate | $\mathrm{V}_{\text {OUT }}=5 \mathrm{~V}$ Step | $+25^{\circ} \mathrm{C}$ | IV | 700 | 1200 |  | V/ $/ \mathrm{s}$ |
| Rise/Fall Time | $\mathrm{V}_{\text {OUT }}=1 \mathrm{~V}$ Step | $+25^{\circ} \mathrm{C}$ | IV |  | 1.1 | 1.7 | ns |
|  | $\mathrm{V}_{\text {Out }}=1 \mathrm{~V}$ Step | $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ | IV |  | 1.3 | 1.9 | ns |
|  | $\mathrm{V}_{\text {Out }}=5 \mathrm{~V}$ Step | $+25^{\circ} \mathrm{C}$ | IV |  | 4.2 | 5.7 | ns |
|  | $\mathrm{V}_{\text {OUT }}=5 \mathrm{~V}$ Step | $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ | IV |  | 5.0 | 6.5 | ns |
| Overshoot Amplitude Settling Time | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ Step | Full ${ }_{\text {max }}$ | IV |  | 2 | 12 | \% |
| Settling Time |  |  |  |  |  |  |  |
| To 0.1\% | $\mathrm{V}_{\text {Out }}=2 \mathrm{~V}$ Step | $\mathrm{T}_{\text {min }}$ to +25 | IV |  | 6 | 10 | ns |
| To 0.1\% ${ }^{\text {To 0.02\% }}$ | $\mathrm{V}_{\text {Out }}=2 \mathrm{~V}$ Step | $\mathrm{T}_{\text {max }}$ to +25 | IV |  | 7 | 12 | ns |
| To 0.02\% ${ }^{4}$ | $\mathrm{V}_{\text {OUt }}=2 \mathrm{~V}$ Step $\mathrm{V}_{\text {OUt }}=2 \mathrm{~V}$ Step | $\mathrm{T}_{\text {min }}$ to +25 | V |  | 8 12 |  | ns |
| Differential Gain | 4.4 MHz | max $+25^{\circ} \mathrm{C}$ | V |  | 0.015 |  | \% |
| Differential Phase | 4.4 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 0.025 |  | Degree |
| SUPPLY CURRENTS |  |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{cc}}\left(+\mathrm{I}_{\mathrm{s}}\right)$ | $\mathrm{V}_{\mathrm{cc}}=+5 \mathrm{~V}$ | Full | II |  | 19 | 26 | mA |
| $\mathrm{V}_{\mathrm{EE}}\left(-\mathrm{I}_{\mathrm{S}}\right)$ | $\mathrm{V}_{\mathrm{EE}}=-5 \mathrm{~V}$ | Full | II |  | 19 | 26 | mA |

NOTES
${ }^{1}$ Absolute maximum ratings are limiting values to be applied individually, and beyond which the serviceability of the circuit may be impaired. Functional operability is not necessarily implied. Exposure to absolute maximum rating conditions for an extended period of time may affect device reliability.
${ }^{2}$ Output is short-circuit protected to ground, but not to supplies. Prolonged short circuit to ground may affect device reliability.
${ }^{3}$ Typical thermal impedances (part soldered onto board): Mini-DIP (N): $\theta_{\mathrm{JA}}=110^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=30^{\circ} \mathrm{C} / \mathrm{W} ;$ SOIC $(\mathrm{R}): \theta_{\mathrm{JA}}=150^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=50^{\circ} \mathrm{C} / \mathrm{W}$; $\operatorname{Cerdip}(\mathrm{Q}): \theta_{\mathrm{JA}}=110^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=20^{\circ} \mathrm{C} / \mathrm{W}$.
${ }^{4}$ Short-term settling with $50 \Omega$ source impedance.

## EXPLANATION OF TEST LEVELS

## Test Level

I $100 \%$ Production tested.
II $\quad 100 \%$ Production tested at $+25^{\circ} \mathrm{C}$ and sample tested at specified temperatures. AC testing of AN and AR grades done on sample basis only.
III Sample tested only.
IV Parameter is guaranteed by design and characterization testing.
V Typical value.
VI S versions are $100 \%$ production tested at temperature extremes. Other grades are sample tested at extremes.

## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD9630AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | N-8 |
| AD9630AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin SOIC | R-8 |
| AD9630AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Cerdip | Q-8 |
| AD9630 Chips | $+25^{\circ} \mathrm{C}$ | Dice |  |

*For outline information see Package Information section.


## THEORY OF OPERATION

The AD9630 is a wide-bandwidth, closed-loop, unity-gain buffer which makes use of a new voltage-feedback architecture (Patent Pending). This architecture brings together wide bandwidth and high slew rate along with exceptional dc linearity. Most previous wide bandwidth buffers achieved their bandwidth by utilizing an open-loop topology which sacrificed both dc linearity and frequency distortion when driven into low load impedances. The design's high loop correction factor radically improves de linearity and distortion characteristics without diminishing bandwidth. This, in combination with high slew rate, results in exceptionally low distortion over a wide frequency range.
The AD9630 is an excellent choice to drive high speed and high resolution analog-to-digital Converters. Its output stage is designed to drive high speed flash converters with minimal or no series resistance. A current booster built into the output driver helps to maintain low distortion.
Parasitic or load capacitance ( $>7 \mathrm{pF}$ ) connected directly to the AD9630 output will result in frequency peaking. A small series resistor ( $\mathbf{R}_{\mathbf{S}}$ ) connected between the buffer output and capacitive load will negate this effect. Figure 1 shows the optimal value of $R_{S}$ as a function of $C_{L}$ to obtain the flattest frequency response. Figure 2 illustrates frequency response for various capacitive loads utilizing the recommended $\mathrm{R}_{\mathbf{S}}$.


Figure 1. Recommended $R_{S}$ vs. $C_{L}$


Figure 2. Frequency Response vs. $C_{L}$ with Recommended $R_{S}$

In pulse mode applications, with $\mathbf{R}_{S}$ equal to approximately 12 ohms, capacitive loads of up to 50 pF can be driven with minimal settling time degradation.

## FEATURES

Wide Bandwidth<br>Small Signal<br>Large Signal ( 4 V p-p) $175 \mathbf{M H z}$<br>Ultralow Distortion (SFDR), Low Noise<br>-113 dBc typ @ 1 MHz<br>-95 dBc typ @ 5 MHz<br>-72 dBc typ @ 20 MHz<br>+46 dBc 3rd Order Intercept @ 25 MHz<br>$7.0 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ Spectral Noise Density<br>High Speed<br>Slew Rate 1300 V/ $\mu \mathrm{s}$<br>Settling 16 ns to $0.01 \%$, 2 V Step<br>$\pm 3 \mathrm{~V}$ to $\pm 5 \mathrm{~V}$ Supply Operation<br>17 mA Supply Current

APPLICATIONS
ADC Input Driver
Differential Amplifiers
IF/RF Amplifiers
Pulse Amplifiers
Professional Video
DAC Current to Voltage
Baseband and Video Communications
Pin Diode Receivers
Active Filters/Integrators/Log Amps

## PRODUCT DESCRIPTION

The AD9631 and AD9632 are very high speed and wide bandwidth amplifiers. They are an improved performance alternative to the AD9621 and AD9622. The AD9631 is unity gain stable. The AD9632 is stable at gains of two or greater. Utilizing a voltage feedback architecture, the AD9631/AD9632's exceptional settling time, bandwidth, and low distortion meet the requirements of many applications which previously depended on current feedback amplifiers. Its classical op amp structure works much more predictably in many designs.

A proprietary design architecture has produced an amplifier that combines many of the best characteristics of both current feedback and voltage feedback amplifiers. The AD9631 and AD9632 exhibit exceptionally fast and accurate pulse response ( 16 ns to $0.01 \%$ ) as well as extremely wide small signal and large signal bandwidth and ultralow distortion. The AD9631 achieves -72 dBc at 20 MHz with 320 MHz small signal and 175 MHz large signal bandwidths.

## FUNCTIONAL BLOCK DIAGRAM

8-Pin Plastic Mini-DIP (N), Cerdip (Q), and SO (R) Packages


These characteristics position the AD9631/AD9632 ideally for driving flash as well as high resolution ADCs. Additionally, the balanced high impedance inputs of the voltage feedback architecture allow maximum flexibility when designing active filters.
The AD9631 is offered in industrial $\left(-40^{\circ} \mathrm{C}\right.$ to $\left.+85^{\circ} \mathrm{C}\right)$ and military $\left(-55^{\circ} \mathrm{C}\right.$ to $\left.+125^{\circ} \mathrm{C}\right)$ temperature ranges and the AD 9632 in industrial. Industrial versions are available in plastic DIP and SOIC; MIL versions are packaged in cerdip.


Figure 1. AD9631 Harmonic Distortion vs. Frequency, $G=+1$

[^171]

| Parameter | Conditions | AD9631A |  |  | AD9632A |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max | Min | Typ | Max |  |
| DYNAMIC PERFORMANCE |  |  |  |  |  |  |  |  |
| Bandwidth ( -3 dB ) |  |  |  |  |  |  |  |  |
| Small Signal | $\mathrm{V}_{\text {OUT }} \leq 0.4 \mathrm{~V}$ p-p | 220 | 320 |  | 180 | 250 |  | MHz |
| Large Signal ${ }^{1}$ | $\mathrm{V}_{\text {OUT }}=4 \mathrm{~V}$ p-p | 150 | 175 |  | 155 | 180 |  | MHz |
| Bandwidth for 0.1 dB Flatness | $\mathrm{V}_{\text {OUT }}=300 \mathrm{mV}$ p-p |  |  |  |  |  |  |  |
|  | $9631, \mathrm{R}_{\mathrm{F}}=140 \Omega ; 9632, \mathrm{R}_{\mathrm{F}}=425 \Omega$ |  | 130 |  |  | 130 |  | MHz |
| Slew Rate, Average +/- | $\mathrm{V}_{\text {OUT }}=4 \mathrm{~V}$ Step | 1000 | 1300 |  | 1200 | 1500 |  | V/ $/ \mathrm{s}$ |
| Rise/Fall Time | $\mathrm{V}_{\text {OUT }}=0.5 \mathrm{~V}$ Step |  | 1.2 |  |  | 1.4 |  | ns |
|  | $\mathrm{V}_{\text {OUT }}=4 \mathrm{~V}$ Step |  | 2.5 |  |  | 2.1 |  | ns |
| Settling Time |  |  |  |  |  |  |  |  |
| To 0.1\% | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ Step |  | 11 |  |  | 11 |  | ns |
| To 0.01\% | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ Step |  | 16 |  |  | 16 |  | ns |
| HARMONIC/NOISE PERFORMANCE |  |  |  |  |  |  |  |  |
| 2nd Harmonic Distortion | 2 V p-p; $20 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=100 \Omega$ |  | -64 | -57 |  | -54 | -47 | dBc |
|  | $\mathrm{R}_{\mathrm{L}}=500 \Omega$ |  | -72 | -65 |  | -72 | -65 | dBc |
| 3rd Harmonic Distortion | 2 V p-p; $20 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=100 \Omega$ |  | -76 | -69 |  | -74 | -67 | dBc |
|  | $\mathrm{R}_{\mathrm{L}}=500 \Omega$ |  | -81 | -74 |  | -81 | -74 | dBc |
| 3rd Order Intercept | 25 MHz |  | +46 |  |  | +41 |  | dBm |
| Noise Figure | $\mathrm{R}_{\mathrm{S}}=50 \Omega$ |  | 18 |  |  | 14 |  |  |
| Input Voltage Noise | 1 MHz to 200 MHz |  | 7.0 |  |  | 4.3 |  | $\mathrm{nV} \sqrt{\mathrm{Hz}}$ |
| Input Current Noise | 1 MHz to 200 MHz |  | 2.5 |  |  | 2.0 |  | $\mathrm{pA} \sqrt{\mathrm{Hz}}$ |
| Average Equivalent Integrated |  |  |  |  |  |  |  |  |
| Differential Gain Error ( 3.58 MHz ) | $\mathrm{R}_{\mathrm{L}}=150 \Omega$ |  | 0.03 | 0.06 |  | 0.02 | 0.04 |  |
| Differential Phase Error ( 3.58 MHz ) | $\mathrm{R}_{\mathrm{L}}=150 \Omega$ |  | 0.02 | 0.04 |  | 0.02 | 0.04 | Degree |
| Phase Nonlinearity | dc to 100 MHz |  | 1.1 |  |  | 1.1 |  | Degree |
| DC PERFORMANCE ${ }^{2}, R_{L}=150 \Omega$ |  |  |  |  |  |  |  |  |
| Input Offset Voltage ${ }^{3}$ | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ |  |  | 13 |  |  | 8 | mV |
| Offset Voltage Drift |  |  | $\pm 10$ |  |  | $\pm 10$ |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Bias Current |  |  | 2 | 7 |  |  | 7 | $\mu \mathrm{A}$ |
|  | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ |  |  | 10 |  |  | 10 | $\mu \mathrm{A}$ |
| Input Offset Current |  |  | 0.1 | 3 |  | 0.1 | 3 | $\mu \mathrm{A}$ |
|  | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ |  |  | 5 |  |  | 5 | $\mu \mathrm{A}$ |
| Common-Mode Rejection Ratio | $\mathrm{V}_{\mathrm{CM}}= \pm 2.5 \mathrm{~V}$ | 70 | 90 |  | 70 | 90 |  | dB |
| Open-Loop Gain | $\mathrm{V}_{\text {OUT }}= \pm 2.5 \mathrm{~V}$ | 46 | 52 |  | 46 | 52 |  | dB |
|  | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ | 40 |  |  | 40 |  |  | dB |
| INPUT CHARACTERISTICS |  |  |  |  |  |  |  |  |
| Input Resistance |  |  | 500 |  |  | 500 |  | k ת |
| Input Capacitance |  |  | 1.2 |  |  | 1.2 |  | pF |
| Input Common-Mode Voltage Range |  |  | $\pm 3.4$ |  |  | $\pm 3.4$ |  | V |
| OUTPUT CHARACTERISTICS |  |  |  |  |  |  |  |  |
| Output Voltage Range, $\mathrm{R}_{\mathrm{L}}=150 \Omega$ |  | $\pm 3.2$ | $\pm 3.9$ |  | $\pm 3.2$ | $\pm 3.9$ |  | V |
| Output Current |  |  | 70 |  |  | 70 |  | mA |
| Output Resistance |  |  | 0.3 |  |  | 0.3 |  | $\Omega$ |
| Short Circuit Current |  |  | 240 |  |  | 240 |  | mA |
| POWER SUPPLY |  |  |  |  |  |  |  |  |
| Operating Range |  | $\pm 3.0$ | $\pm 5.0$ | $\pm 6.0$ | $\pm 3.0$ |  | $\pm 6.0$ | V |
| Quiescent Current |  |  | 17 | 18 |  |  | 17 | mA |
|  | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ |  |  | 21 |  |  | 20 | mA |
| Power Supply Rejection Ratio | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ | 50 | 60 |  | 56 | 66 |  | dB |

[^172]
## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

Supply Voltage<br>12.6 V<br>Voltage Swing $\times$ Bandwidth Product<br>$550 \mathrm{~V} \times \mathrm{MHz}$<br>Internal Power Dissipation ${ }^{2}$<br>Plastic Package (N)<br>Small Outline Package (R)<br>Input Voltage (Common Mode)

Output Short Circuit Duration
Observe Power Derating Curves
Storage Temperature Range N, R $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Operating Temperature Range (A Grade) $\quad-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Lead Temperature Range (Soldering 10 sec )
$+300^{\circ} \mathrm{C}$

## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ Specification is for device in free air:
8-Pin Plastic Package: $\theta_{\mathrm{JA}}=90^{\circ} \mathrm{C} /$ Watt
8-Pin SOIC Package: $\theta_{\mathrm{JA}}=140^{\circ} \mathrm{C} /$ Watt


## MAXIMUM POWER DISSIPATION

The maximum power that can be safely dissipated by these devices is limited by the associated rise in junction temperature. The maximum safe junction temperature for plastic encapsulated devices is determined by the glass transition temperature of the plastic, approximately $+150^{\circ} \mathrm{C}$. Exceeding this limit temporarily may cause a shift in parametric performance due to a change in the stresses exerted on the die by the package. Exceeding a junction temperature of $+175^{\circ} \mathrm{C}$ for an extended period can result in device failure.
While the AD9631 and AD9632 are internally short circuit protected, this may not be sufficient to guarantee that the maximum junction temperature $\left(+150^{\circ} \mathrm{C}\right)$ is not exceeded under all conditions. To ensure proper operation, it is necessary to observe the maximum power derating curves.


Figure 2. Plot of Maximum Power Dissipation vs. Temperature

## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD9631AN | -40 C to $+85^{\circ} \mathrm{C}$ | Plastic DIP | $\mathrm{N}-8$ |
| AD9631AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | SOIC | $\mathrm{R}-8$ |
| AD9631(SMD) | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Cerdip <br> AD9631-EB | $\mathrm{Q}-8$ |
| AD963ation |  |  |  |
| AD9632AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Board <br> Plastic DIP | $\mathrm{N}-8$ |
| AD9632-EB | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | SOIC <br> Evaluation | $\mathrm{R}-8$ |

*N = Plastic DIP; Q = Cerdip; R=SOIC (Small Outline Integrated Circuit).
For outline information see Package Information section.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although these devices feature proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


## THEORY OF OPERATION

## General

The AD9631 and AD9632 are wide bandwidth, voltage feedback amplifiers. Since their open-loop frequency response follows the conventional $6 \mathrm{~dB} /$ octave roll-off, their gain bandwidth product is basically constant. Increasing their closed-loop gain results in a corresponding decrease in small signal bandwidth. This can be observed by noting the bandwidth specification between the AD9631 (gain of 1) and AD9632 (gain of 2). The AD9631/AD9632 typically maintain 65 degrees of phase margin. This high margin minimizes the effects of signal and noise peaking.

## Feedback Resistor Choice

The value of the feedback resistor is critical for optimum performance on the AD9631 (gain +1) and less critical as the gain increases. Therefore, this section is specifically targeted at the AD9631.
At minimum stable gain (+1), the AD9631 provides optimum dynamic performance with $R_{F}=140 \Omega$. This resistor acts only as a parasitic suppressor against damped RF oscillations that can occur due to lead (input, feedback) inductance and parasitic capacitance. This value of $R_{F}$ provides the best combination of wide bandwidth, low parasitic peaking, and fast settling time.
In fact, for the same reasons, a $100-130 \Omega$ resistor should be placed in series with the positive input for other AD9631 noninverting and all AD9631 inverting configurations. The correct connection is shown in Figures 57 and 58.


Figure 57. Noninverting Operation


Figure 58. Inverting Operation
When the AD9631 is used in the transimpedance (I to V ) mode, such as in photodiode detection, the value of $\mathrm{R}_{\mathrm{F}}$ and diode capacitance $\left(\mathrm{C}_{\mathrm{I}}\right)$ are usually known. Generally, the value of $\mathrm{R}_{\mathrm{F}}$ selected will be in the $\mathrm{k} \Omega$ range, and a shunt capacitor $\left(\mathrm{C}_{\mathrm{F}}\right)$ across $\mathrm{R}_{\mathrm{F}}$ will be required to maintain good amplifier stability. The value of $C_{F}$ required to maintain optimal flatness ( $<1 \mathrm{~dB}$ Peaking) and settling time can be estimated as:

$$
C_{F} \cong\left[\left(2 \omega_{O} C_{I} R_{F}-1\right) / \omega_{O}^{2} R_{F}^{2}\right]^{1 / 2}
$$

where $\omega_{0}$ is equal to the unity gain bandwidth product of the amplifier in rad/sec, and $\mathrm{C}_{\mathrm{I}}$ is the equivalent total input capacitance at the inverting input. Typically $\omega_{\mathrm{O}}=800 \times 10^{6}$ $\mathrm{rad} / \mathrm{sec}$ (see Open-Loop Frequency Response curve (Figure 17).
As an example, choosing $R_{F}=10 \mathrm{k} \Omega$ and $C_{I}=5 \mathrm{pF}$, requires $\mathrm{C}_{\mathrm{F}}$ to be 1.1 pF (Note: $\mathrm{C}_{\mathrm{I}}$ includes both source and parasitic circuit capacitance). The bandwidth of the amplifier can be estimated using the $\mathrm{C}_{\mathrm{F}}$ calculated as:

$$
f_{3 d B} \cong \frac{1.6}{2 \pi R_{F} C_{F}}
$$



Figure 59. Transimpedance Configuration

## AD9631/AD9632

For general voltage gain applications, the amplifier bandwidth can be closely estimated as:

$$
f_{3 d B} \cong \frac{\omega_{O}}{2 \pi\left[1+\left(\frac{R_{F}}{R_{G}}\right)\right]}
$$

This estimation loses accuracy for gains of $+2 /-1$ or lower due to the amplifier's damping factor. For these "low gain" cases, the bandwidth will actually extend beyond the calculated value (see Closed-Loop BW plots, Figures 15 and 27).
As a rule of thumb, capacitor $\mathrm{C}_{\mathrm{F}}$ will not be required if:

$$
\left(R_{F} \| R_{G}\right) \times C_{I} \leq \frac{N G}{4 \omega_{O}}
$$

where $N G$ is the Noise Gain $\left(1+\mathrm{R}_{\mathrm{F}} / \mathrm{R}_{\mathrm{G}}\right)$ of the circuit. For most voltage gain applications, this should be the case.

## Pulse Response

Unlike a traditional voltage feedback amplifier, where the slew speed is dictated by its front end dc quiescent current and gain bandwidth product, the AD9631 and AD9632 provide "on demand" current that increases proportionally to the input "step" signal amplitude. This results in slew rates ( $1300 \mathrm{~V} / \mu \mathrm{s}$ ) comparable to wideband current feedback designs. This, combined with relatively low input noise current ( $2.0 \mathrm{pA} / \sqrt{\mathrm{Hz}}$ ), gives the AD9631 and AD9632 the best attributes of both voltage and current feedback amplifiers.

## Large Signal Performance

The outstanding large signal operation of the AD9631 and AD9632 is due to a unique, proprietary design architecture. In order to maintain this level of performance, the maximum $550 \mathrm{~V}-\mathrm{MHz}$ product must be observed, (e.g., @ 100 MHz , $\mathrm{V}_{\mathrm{O}} \leq 5.5 \mathrm{~V}$ p-p).

## Power Supply Bypassing

Adequate power supply bypassing can be critical when optimizing the performance of a high frequency circuit. Inductance in the power supply leads can form resonant circuits that produce peaking in the amplifier's response. In addition, if large current transients must be delivered to the load, then bypass capacitors (typically greater than $1 \mu \mathrm{~F}$ ) will be required to provide the best settling time and lowest distortion. A parallel combination of at least $4.7 \mu \mathrm{~F}$, and between $0.1 \mu \mathrm{~F}$ and $0.01 \mu \mathrm{~F}$, is recommended. Some brands of electrolytic capacitors will require a small series damping resistor $\approx 4.7 \Omega$ for optimum results.

## Driving Capacitive Loads

The AD9631 and AD9632 were designed primarily to drive nonreactive loads. If driving loads with a capacitive component is desired, the best frequency response is obtained by the addition of a small series resistance as shown in Figure 60. The accompanying graph shows the optimum value for $\mathrm{R}_{\text {SERIES }}$ vs. capacitive load. It is worth noting that the frequency response of the circuit when driving large capacitive loads will be dominated by the passive roll-off of $\mathrm{R}_{\text {SERIES }}$ and $\mathrm{C}_{\mathrm{L}}$.


Figure 60. Driving Capacitive Loads


Figure 61. Recommended $R_{\text {SERIES }}$ vs. Capacitive Load

Improved Second Source to the EL2020

## ADEL2020

## FEATURES

Ideal for Video Applications

### 0.02\% Differential Gain

$0.04^{\circ}$ Differential Phase
0.1 dB Bandwidth to $25 \mathrm{MHz}(\mathrm{G}=+2)$

High Speed
90 MHz Bandwidth ( -3 dB )
500 V/ $\mu$ s Slew Rate
60 ns Settling Time to $0.1 \%\left(V_{0}=10 \mathrm{~V}\right.$ Step)
Low Noise
$2.9 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ Input Voltage Noise
Low Power
6.8 mA Supply Current
2.1 mA Supply Current (Power-Down Mode)

High Performance Disable Function Turn-Off Time of 100 ns Input to Output Isolation of 54 dB (Off State)

## PRODUCT DESCRIPTION

The ADEL2020 is an improved second source to the EL2020. This op amp improves on all the key dynamic specifications while offering lower power and lower cost. The ADEL2020 offers $50 \%$ more bandwidth and gain flatness of 0.1 dB to beyond 25 MHz . In addition, differential gain and phase are less than $0.05 \%$ and $0.05^{\circ}$ while driving one back terminated cable ( $150 \Omega$ ).

The ADEL2020 offers other significant improvements. The most important of these is lower power supply current, $33 \%$ less


Fine-Scale Gain (Normalized) vs. Frequency for Various Supply Voltages. $R_{F}=750 \Omega$, Gain $=+2$

## CONNECTION DIAGRAMS

8-Pin Plastic Mini-DIP (N)
20-Pin Small Outline Package


than the competition while offering higher output drive. Important specs like voltage noise and offset voltage are less than half of those for the EL2020.

The ADEL2020 also features an improved disable feature. The disable time (to high output impedance) is 100 ns with guaranteed break before make. Finally the ADEL2020 is offered in the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ in both plastic DIP and SOIC package.


Differential Gain and Phase vs. Supply Voltage

ADEL2020 - SPECIFICATIONS
(@ $T_{A}=+25^{\circ} \mathrm{C}$ and $V_{S}= \pm 15 \mathrm{~V}$ dc, $\mathrm{R}_{\mathrm{L}}=150 \Omega$ unless otherwise noted)

| Parameter | Conditions | Temperature | ADEL2020A |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max |  |
| INPUT OFFSET VOLTAGE Offset Voltage Drift |  | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ |  | $\begin{aligned} & 1.5 \\ & 2.0 \\ & 7 \end{aligned}$ | $\begin{aligned} & 7.5 \\ & 10.0 \end{aligned}$ | mV <br> mV <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| ```COMMON-MODE REJECTION \(V_{\text {os }}\) \(\pm\) Input Current``` | $\mathrm{V}_{\mathrm{CM}}= \pm 10 \mathrm{~V}$ | $\begin{aligned} & \mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }} \\ & \mathrm{T}_{\text {MIN }}-\mathrm{T}_{\mathrm{MAX}} \end{aligned}$ | 50 | $\begin{aligned} & 64 \\ & 0.1 \end{aligned}$ | 1.0 | $\begin{aligned} & \mathrm{dB} \\ & \mu \mathrm{~A} / \mathrm{V} \end{aligned}$ |
| POWER SUPPLY REJECTION $\mathrm{V}_{\mathrm{os}}$ <br> $\pm$ Input Current | $\mathrm{V}_{\mathrm{S}}= \pm 4.5 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | $\begin{aligned} & \mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }} \\ & \mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }} \end{aligned}$ | 65 | $\begin{aligned} & 72 \\ & 0.05 \end{aligned}$ | 0.5 | dB $\mu \mathrm{A} / \mathrm{V}$ |
| INPUT BIAS CURRENT | -Input <br> +Input | $\begin{aligned} & \mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }} \\ & \mathrm{T}_{\text {MIN }}-\mathrm{T}_{\mathrm{MAX}} \end{aligned}$ |  | $\begin{aligned} & 0.5 \\ & 1 \end{aligned}$ | $\begin{aligned} & 7.5 \\ & 15 \end{aligned}$ | $\begin{aligned} & \mu \mathrm{A} \\ & \mu \mathrm{~A} \end{aligned}$ |
| INPUT CHARACTERISTICS <br> +Input Resistance <br> -Input Resistance <br> +Input Capacitance |  |  |  | $\begin{aligned} & 10 \\ & 40 \\ & 2 \\ & \hline \end{aligned}$ |  | $\begin{aligned} & \mathrm{M} \Omega \\ & \Omega \\ & \mathrm{pF} \end{aligned}$ |
| OPEN-LOOP TRANSRESISTANCE | $\begin{aligned} & \mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{L}}=400 \Omega \end{aligned}$ | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ | 1 | 3.5 |  | $\mathrm{M} \Omega$ |
| OPEN-LOOP DC VOLTAGE GAIN | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=400 \Omega, \mathrm{~V}_{\mathrm{OUT}}= \pm 10 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{L}}=100 \Omega, \mathrm{~V}_{\text {OUT }}= \pm 2.5 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & \mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }} \\ & \mathrm{T}_{\mathrm{MIN}^{-}}-\mathrm{T}_{\text {MAX }} \end{aligned}$ | $\begin{aligned} & 80 \\ & 76 \end{aligned}$ | $\begin{aligned} & 100 \\ & 88 \end{aligned}$ |  | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \end{aligned}$ |
| OUTPUT VOLTAGE SWING <br> Short-Circuit Current Output Current | $\mathrm{R}_{\mathrm{L}}=400 \Omega$ | $\begin{aligned} & \mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }} \\ & \mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }} \end{aligned}$ | $\begin{aligned} & \pm 12.0 \\ & 30 \end{aligned}$ | $\begin{aligned} & \pm 13.0 \\ & 150 \\ & 60 \end{aligned}$ |  | V <br> mA <br> mA |
| POWER SUPPLY <br> Operating Range <br> Quiescent Current <br> Power-Down Current <br> Disable Pin Current <br> Min Disable Pin Current to Disable | Disable Pin $=0 \mathrm{~V}$ | $\begin{aligned} & \mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }} \\ & \mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }} \\ & \mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }} \\ & \mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }} \end{aligned}$ | $\pm 3.0$ | $\begin{aligned} & 6.8 \\ & 2.1 \\ & 290 \\ & 30 \end{aligned}$ | $\begin{aligned} & \pm 18 \\ & 10.0 \\ & 3.0 \\ & 400 \end{aligned}$ | V <br> mA <br> mA <br> $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ |
| DYNAMIC PERFORMANCE <br> 3 dB Bandwidth <br> 0.1 dB Bandwidth Full Power Bandwidth <br> Slew Rate <br> Settling Time to $0.1 \%$ Differential Gain Differential Phase | $\begin{aligned} & \mathrm{G}=+1 ; \mathrm{R}_{\mathrm{FB}}=820 \\ & \mathrm{G}=+2 ; \mathrm{R}_{\mathrm{FB}}=750 \\ & \mathrm{G}=+10 ; \mathrm{R}_{\mathrm{FB}}=680 \\ & \mathrm{G}=+2 ; \mathrm{R}_{\mathrm{FB}}=750 \\ & \mathrm{~V}_{\mathrm{O}}=20 \mathrm{~V} \mathrm{p}-\mathrm{p}, \\ & \mathrm{R}_{\mathrm{L}}=400 \Omega \\ & \mathrm{R}_{\mathrm{L}}=400 \Omega, \mathrm{G}=+1 \\ & 10 \mathrm{~V} \operatorname{Step}, \mathrm{G}=-1 \\ & \mathrm{f}=3.58 \mathrm{MHz} \\ & \mathrm{f}=3.58 \mathrm{MHz} \end{aligned}$ |  |  | 90 70 <br> 30 <br> 25 <br> 8 <br> 500 <br> 60 <br> 0.02 <br> 0.04 |  | MHz <br> MHz <br> MHz <br> MHz <br> MHz <br> V/ $/ \mathrm{s}$ <br> ns <br> \% <br> Degree |
| INPUT VOLTAGE NOISE | $\mathrm{f}=1 \mathrm{kHz}$ |  |  | 2.9 |  | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| INPUT CURRENT NOISE | $\begin{aligned} & -\mathrm{I}_{\mathrm{IN}}, \mathrm{f}=1 \mathrm{kHz} \\ & +\mathrm{I}_{\mathrm{IN}}, \mathrm{f}=1 \mathrm{kHz} \end{aligned}$ |  |  | $\begin{aligned} & 13 \\ & 1.5 \end{aligned}$ |  | $\begin{aligned} & \mathrm{pA} / \sqrt{\mathrm{Hz}} \\ & \mathrm{pA} / \sqrt{\mathrm{Hz}} \end{aligned}$ |
| OUTPUT RESISTANCE | Open Loop ( 5 MHz ) |  |  | 15 |  | $\Omega$ |

[^173]
## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 18$ V
Internal Power Dissipation ${ }^{2}$. . . . . . . Observe Derating Curves
Output Short Circuit Duration . . . . . Observe Derating Curves
Common-Mode Input Voltage . . . . . . . . . . . . . . . . . . . $\pm \mathrm{V}_{\mathrm{S}}$
Differential Input Voltage . . . . . . . . . . . . . . . . . . . . . $\pm 6$ V
Storage Temperature Range
Plastic DIP and SOIC . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Operating Temperature Range . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Lead Temperature Range (Soldering 60 sec ) . . . . . . $+300^{\circ} \mathrm{C}$

## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2} 8$-Pin Plastic Package: $\theta_{\mathrm{JA}}=90^{\circ} \mathrm{C} / \mathrm{W}$ att
20-Pin SOIC Package: $\theta_{\mathrm{JA}}=150^{\circ} \mathrm{C} /$ Watt

## ESD SUSCEPTIBILITY

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 volts, which readily accumulate on the human body and on test equipment, can discharge without detection. Although the ADEL2020 features ESD protection circuitry, permanent damage may still occur on these devices if they are subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid any performance degradation or loss of functionality.

## MAXIMUM POWER DISSIPATION

The maximum power that can be safely dissipated by the ADEL2020 is limited by the associated rise in junction temperature. For the plastic packages, the maximum safe junction temperature is $145^{\circ} \mathrm{C}$. If the maximum is exceeded momentarily, proper circuit operation will be restored as soon as the die temperature is reduced. Leaving the device in the "overheated" condition for an extended period can result in device burnout. To ensure proper operation, it is important to observe the derating curves below.
While the ADEL2020 is internally short circuit protected, this may not be sufficient to guarantee that the maximum junction temperature is not exceeded under all conditions.




Offset Null Configuration

## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| ADEL2020AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | $\mathrm{N}-8$ |
| ADEL2020AR-20 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 20-Pin Plastic SOIC | R-20 |
| ADEL2020AR-20-REEL | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 20-Pin Plastic SOIC | R-20 |

[^174]

Figure 1. Connection Diagram for $A_{V C L}=+1$


Figure 2. Closed-Loop Gain and Phase vs. Frequency,
$G=+1, R_{L}=150 \Omega, R_{F}=1 \mathrm{k} \Omega$ for $\pm 15 \mathrm{~V}, 910 \Omega$ for $\pm 5 \mathrm{~V}$


Figure 3. Closed-Loop Gain and Phase vs. Frequency, $G=+1, R_{L}=1 \mathrm{k} \Omega, R_{F}=1 \mathrm{k} \Omega$ for $\pm 15 \mathrm{~V}, 910 \Omega$ for $\pm 5 \mathrm{~V}$


Figure 4. $-3 d B$ Bandwidth vs. Supply Voltage, Gain $=+1, R_{L}=150 \Omega$


Figure 5. Connection Diagram for $A_{v C L}=-1$


Figure 6. Closed-Loop Gain and Phase vs. Frequency, $G=-1, R_{L}=150 \Omega, R_{F}=680 \Omega$ for $\pm 15 \mathrm{~V}, 620 \Omega$ for $\pm 5 \mathrm{~V}$


Figure 7. Closed-Loop Gain and Phase vs. Frequency, $G=-1, R_{L}=1 \mathrm{k} \Omega, R_{F}=680 \Omega$ for $V_{S}= \pm 15 \mathrm{~V}, 620 \Omega$ for $\pm 5 \mathrm{~V}$


Figure 8. $-3 d B$ Bandwidth vs. Supply Voltage, Gain $=-1, R_{L}=150 \Omega$


Figure 9. Connection Diagram for $A_{v c L}=+2$


Figure 10. Closed-Loop Gain and Phase vs. Frequency, $G=+2, R_{L}=150 \Omega, R_{F}=750 \Omega$ for $\pm 15 \mathrm{~V}, 715 \Omega$ for $\pm 5 \mathrm{~V}$


Figure 11. Closed-Loop Gain and Phase vs. Frequency, $G=+2, R_{L}=1 \mathrm{k} \Omega, R_{F}=750 \Omega$ for $\pm 15 \mathrm{~V}, 715 \Omega$ for $\pm 5 \mathrm{~V}$


Figure 12. $-3 d B$ Bandwidth vs. Supply Voltage,
Gain $=+2, R_{L}=150 \Omega$


Figure 13. Connection Diagram for $A_{v C L}=+10$


Figure 14. Closed-Loop Gain and Phase vs. Frequency, $G=+10, R_{L}=150 \mathrm{k} \Omega$


Figure 15. Closed-Loop Gain and Phase vs. Frequency, $G=+10, R_{L}=1 \mathrm{k} \Omega$


Figure 16. $-3 d B$ Bandwidth vs. Supply Voltage,
Gain $=+10, R_{L}=150 \Omega$


Figure 17. Maximum Undistorted Output Voltage vs. Frequency


Figure 18. Power Supply Rejection vs. Frequency


Figure 19. Input Voltage and Current Noise vs. Frequency


Figure 20. Closed-Loop Output Resistance vs. Frequency


Figure 21. Supply Current vs. Junction Temperature


Figure 22. Slew Rate vs. Supply Voltage

## GENERAL DESIGN CONSIDERATIONS

The ADEL2020 is a current feedback amplifier optimized for use in high performance video and data acquisition systems. Since it uses a current feedback architecture, its closed-loop bandwidth depends on the value of the feedback resistor. The -3 dB bandwidth is also somewhat dependent on the power supply voltage. Lowering the supplies increases the values of internal capacitances, reducing the bandwidth. To compensate for this, smaller values of feedback resistor are used at lower supply voltages.

## POWER SUPPLY BYPASSING

Adequate power supply bypassing can be critical when optimizing the performance of a high frequency circuit. Inductance in the power supply leads can contribute to resonant circuits that produce peaking in the amplifier's response. In addition, if large current transients must be delivered to the load, then bypass capacitors (typically greater than $1 \mu \mathrm{~F}$ ) will be required to provide the best settling time and lowest distortion. Although the recommended $0.1 \mu \mathrm{~F}$ power supply bypass capacitors will be sufficient in most applications, more elaborate bypassing (such as using two paralleled capacitors) may be required in some cases.

## CAPACITIVE LOADS

When used with the appropriate feedback resistor, the ADEL2020 can drive capacitive loads exceeding 1000 pF directly without oscillation. Another method of compensating for large load capacitance is to insert a resistor in series with the loop output. In most cases, less than $50 \Omega$ is all that is needed to achieve an extremely flat gain response.

## OFFSET NULLING

A $10 \mathrm{k} \Omega$ pot connected between Pins 1 and 5 , with its wiper connected to $\mathrm{V}+$, can be used to trim out the inverting input current (with about $\pm 20 \mu \mathrm{~A}$ of range). For closed-loop gains above about 5 , this may not be sufficient to trim the output offset voltage to zero. Tie the pot's wiper to ground through a large value resistor ( $50 \mathrm{k} \Omega$ for $\pm 5 \mathrm{~V}$ supplies, $150 \mathrm{k} \Omega$ for $\pm 15 \mathrm{~V}$ supplies) to trim the output to zero at high closed-loop gains.

## OPERATION AS A VIDEO LINE DRIVER

The ADEL2020 is designed to offer outstanding performance at closed-loop gains of one or greater. At a gain of 2, the ADEL2020 makes an excellent video line driver. The low differential gain and phase errors and wide -0.1 dB bandwidth are nearly independent of supply voltage and load. For applications requiring widest 0.1 dB bandwidth, it is recommended to use $715 \Omega$ feedback and gain resistors. This will result in about 0.05 dB of peaking and a -0.1 dB bandwidth of 30 MHz on $\pm 15 \mathrm{~V}$ supplies.

## DISABLE MODE

By pulling the voltage on Pin 8 to common ( 0 V ), the ADEL2020 can be put into a disabled state. In this condition, the supply current drops to less than 2.8 mA , the output becomes a high impedance, and there is a high level of isolation from input to output. In the case of a line driver for example, the output impedance will be about the same as for a $1.5 \mathrm{k} \Omega$ resistor (the feedback plus gain resistors) in parallel with a 13 pF capacitor (due to the output) and the input to output isolation will be better than 50 dB at 10 MHz .
Leaving the disable pin disconnected (floating) will leave the part in the enabled state.
In cases where the amplifier is driving a high impedance load, the input to output isolation will decrease significantly if the input signal is greater than about 1.2 V peak to peak. The isolation can be restored to the 50 dB level by adding a dummy load (say $150 \Omega$ ) at the amplifier output. This will attenuate the feedthrough signal. (This is not an issue for multiplexer applications where the outputs of multiple ADEL2020s are tied together as long as at least one channel is in the ON state.) The input impedance of the disable pin is about $35 \mathrm{k} \Omega$ in parallel with a few pF . When grounded, about $50 \mu \mathrm{~A}$ flows out of the disable pin for $\pm 5 \mathrm{~V}$ supplies.
Break before make operation is guaranteed by design. If driven by standard CMOS logic, the disable time (until the output is high impedance), is about 100 ns and the enable time (to low impedance output) is about 160 ns . Since it has an internal pullup resistor of about $35 \mathrm{k} \Omega$, the ADEL2020 can be used with open drain logic as well. In this case, the enable time is increased to about $1 \mu \mathrm{~s}$.
If there is a nonzero voltage present on the amplifier's output at the time it is switched to the disabled state, some additional decay time will be required for the output voltage to relax to zero. The total time for the output to go to zero will generally be about 250 ns and is somewhat dependent on the load impedance.

## FEATURES

Bandwidth - 110 MHz
Slew Rate-3000 V/ $\mu \mathrm{S}$
Low Offset Voltage - < 1 mV
Very Low Noise $-<4 \mathrm{nV} / \sqrt{\mathrm{Hz}}$
Low Supply Current - 8.5 mA Mux
Wide Supply Range $- \pm 5$ to $\pm 15 \mathrm{~V}$
Drives Capacitive Loads
Pin Compatible with BUF03

## APPLICATIONS

Instrumentation Buffer
RF Buffer

## Line Driver

High Speed Current Source
Op Amp Output Current Booster
High Performance Audio
High Speed AD/DA

## GENERAL DESCRIPTION

The BUF04 is a wideband, closed-loop buffer that combines state of the art dynamic performance with excellent dc performance. This combination enables designers to maximize system performance without any speed versus dc accuracy compromises.
Built on a high speed Complementary Bipolar (CB) process for better power performance ratio, the BUF04 consumes less than 8.5 mA operating from $\pm 5 \mathrm{~V}$ or $\pm 15 \mathrm{~V}$ supplies. With a $2000 \mathrm{~V} / \mu \mathrm{s} \min$ slew rate, and 100 MHz gain bandwidth product, the BUF04 is ideally suited for use in high speed applications where low power dissipation is critical.
Full $\pm 10 \mathrm{~V}$ output swing over the extended temperature range along with outstanding ac performance and high loop gain accuracy makes the device useful in high speed data acquisition systems.

FUNCTIONAL BLOCK DIAGRAM


High slew rate and very low noise and THD, coupled with wide input and output dynamic range, make the BUF04 an excellent choice for video and high performance audio circuits.
The BUF04's inherent ability to drive capacitive loads over a wide voltage and temperature range makes it extremely useful for a wide variety of applications in military, industrial, and commercial equipment.
The BUF04 is specified over the extended industrial $\left(-40^{\circ} \mathrm{C}\right.$ to $+85^{\circ} \mathrm{C}$ ) and military ( $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ ) temperature range. BUF04s are available in plastic and ceramic DIP plus SO-8 surface mount packages.
Contact your local sales office for MIL-STD-883 data sheet and availability.

[^175]
## SPECIFICATIONS

## ELECTRICAL CHARACTERISTICS ( $V_{S}= \pm 15.0, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT CHARACTERISTICS <br> Offset Voltage <br> Input Bias Current <br> Input Voltage Range <br> Offset Voltage Drift <br> Offset Null Range | $\begin{aligned} & \mathrm{V}_{\mathrm{OS}} \\ & \mathrm{I}_{\mathrm{B}} \\ & \mathrm{~V}_{\mathrm{CM}} \\ & \Delta \mathrm{~V}_{\mathrm{OS}} / \Delta \mathrm{T} \end{aligned}$ | $\begin{aligned} & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \end{aligned}$ |  | $\begin{aligned} & 0.3 \\ & 1.3 \\ & 0.7 \\ & 2.2 \\ & \pm 13 \\ & 30 \\ & \pm 25 \end{aligned}$ | $\begin{aligned} & 1 \\ & 4 \\ & 5 \\ & 10 \end{aligned}$ | $\begin{aligned} & \mathrm{mV} \\ & \mathrm{mV} \\ & \mu \mathrm{~A} \\ & \mu \mathrm{~A} \\ & \mathrm{~V} \\ & \mu \mathrm{~V} /{ }^{\circ} \mathrm{C} \\ & \mathrm{mV} \end{aligned}$ |
| OUTPUT CHARACTERISTICS <br> Output Voltage Swing <br> Output Current - Continuous Peak Output Current | $\mathrm{V}_{\mathrm{o}}$ <br> $\mathrm{I}_{\text {Out }}$ <br> I | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=150 \Omega, \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \end{aligned}$ <br> Note 2 | $\begin{aligned} & \pm 10.5 \\ & \pm 10 \\ & \pm 13 \\ & \pm 13 \\ & \pm 50 \end{aligned}$ | $\begin{aligned} & \pm 11.1 \\ & \pm 11 \\ & \pm 13.5 \\ & \pm 13.15 \\ & \pm 65 \\ & \pm 80 \end{aligned}$ |  | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~mA} \\ & \mathrm{~mA} \end{aligned}$ |
| TRANSFER CHARACTERISTICS Gain Gain Linearity | $\mathrm{A}_{\mathrm{VCL}}$ <br> NL | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega, \mathrm{~V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{L}}=150 \mathrm{k} \Omega \end{aligned}$ | $\begin{aligned} & 0.995 \\ & 0.995 \end{aligned}$ | $\begin{aligned} & 0.9985 \\ & 0.9980 \\ & 0.005 \\ & 0.008 \end{aligned}$ | $\begin{aligned} & 1.005 \\ & 1.005 \end{aligned}$ | $\begin{aligned} & \text { V/V } \\ & \text { V/V } \\ & \% \\ & \% \end{aligned}$ |
| POWER SUPPLY <br> Power Supply Rejection Ratio <br> Supply Current | $\begin{aligned} & \text { PSRR } \\ & \mathrm{I}_{\mathrm{SY}} \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}= \pm 4.5 \mathrm{~V} \text { to } \pm 18 \mathrm{~V} \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{O}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=\infty \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \end{aligned}$ | $\begin{aligned} & 76 \\ & 76 \end{aligned}$ | $\begin{aligned} & 93 \\ & 93 \\ & 6.9 \\ & 6.9 \end{aligned}$ | $\begin{aligned} & 8.5 \\ & 8.5 \end{aligned}$ | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \\ & \mathrm{~mA} \\ & \mathrm{~mA} \end{aligned}$ |
| DYNAMIC PERFORMANCE <br> Slew Rate <br> Bandwidth <br> Bandwidth <br> Bandwidth <br> Settling Time <br> Differential Phase <br> Differential Gain <br> Input Capacitance | SR <br> BW <br> BW <br> BW | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=70 \mathrm{pF} \\ & -3 \mathrm{~dB}, \mathrm{C}_{\mathrm{L}}=20 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=\infty \\ & -3 \mathrm{~dB}, \mathrm{C}_{\mathrm{L}}=20 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega \\ & -3 \mathrm{~dB}, \mathrm{C}_{\mathrm{L}}=20 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=150 \Omega \\ & \mathrm{~V}_{\mathrm{IN}}= \pm 10 \mathrm{~V} \text { Step to } 0.1 \% \\ & \mathrm{f}=3.58 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=150 \Omega \\ & \mathrm{f}=4.43 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=150 \Omega \\ & \mathrm{f}=3.58 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=150 \Omega \\ & \mathrm{f}=4.43 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=150 \Omega \end{aligned}$ | 2000 | $\begin{aligned} & 3000 \\ & 110 \\ & 110 \\ & 110 \\ & 60 \\ & 0.02 \\ & 0.03 \\ & 0.014 \\ & 0.008 \\ & 3 \end{aligned}$ |  | $\mathrm{V} / \mu \mathrm{s}$ <br> MHz <br> MHz <br> MHz <br> ns <br> Degrees <br> Degrees <br> \% <br> \% <br> pF |
| NOISE PERFORMANCE Voltage Noise Density Current Noise Density | $\begin{aligned} & e_{n} \\ & i_{n} \end{aligned}$ | $\begin{aligned} & \mathrm{f}=1 \mathrm{kHz} \\ & \mathrm{f}=1 \mathrm{kHz} \end{aligned}$ |  | 4 2 |  | $\mathrm{nV} / \sqrt{\overline{\mathrm{Hz}}}$ $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |

[^176]
## BUFO4

ELECTRICAL CHARACTERISTICS
(@ $\mathrm{V}_{\mathrm{S}}= \pm 5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT CHARACTERISTICS <br> Offset Voltage <br> Input Bias Current <br> Input Voltage Range <br> Offset Voltage Drift <br> Offset Null Range | $\begin{aligned} & \mathrm{V}_{\mathrm{OS}} \\ & \mathrm{I}_{\mathrm{B}} \\ & \mathrm{~V}_{\mathrm{CM}} \\ & \Delta \mathrm{~V}_{\mathrm{OS}} / \Delta \mathrm{T} \end{aligned}$ | $\begin{aligned} & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V} \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \end{aligned}$ |  | $\begin{aligned} & 0.8 \\ & 1.0 \\ & 0.15 \\ & 1.6 \\ & \pm 3.0 \\ & 30 \\ & \pm 25 \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 4 \\ & 5 \\ & 10 \end{aligned}$ | mV <br> mV <br> $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ <br> V <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ <br> mV |
| OUTPUT CHARACTERISTICS <br> Output Voltage Swing <br> Output Current - Continuous Peak Output Current | $\mathrm{V}_{\mathrm{o}}$ <br> $\mathrm{I}_{\text {Out }}$ <br> $\mathrm{I}_{\text {OUTP }}$ | $\begin{aligned} & R_{L}=150 \Omega, \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \end{aligned}$ <br> Note 2 | $\begin{aligned} & \pm 3.0 \\ & \pm 2.75 \\ & \pm 3.0 \\ & \pm 3.0 \\ & \pm 40 \end{aligned}$ | $\begin{aligned} & \pm 3.00 \\ & \pm 3.6 \\ & \pm 3.35 \\ & \pm 75 \end{aligned}$ |  | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~mA} \\ & \mathrm{~mA} \end{aligned}$ |
| TRANSFER CHARACTERISTICS <br> Gain <br> Gain Linearity | $\begin{aligned} & \mathrm{A}_{\mathrm{VCL}} \\ & \mathrm{NL} \end{aligned}$ | $\begin{aligned} & \mathbf{R}_{\mathbf{L}}=2 \mathrm{k} \Omega \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathbf{R}_{\mathbf{L}}=1 \mathrm{k} \Omega \end{aligned}$ | $\begin{aligned} & 0.995 \\ & 0.995 \end{aligned}$ | $\begin{aligned} & 0.9977 \\ & 0.005 \end{aligned}$ | $\begin{aligned} & 1.005 \\ & 1.005 \end{aligned}$ | $\begin{aligned} & \text { V/V } \\ & \text { V/V } \\ & \% \end{aligned}$ |
| POWER SUPPLY <br> Power Supply Rejection Ratio <br> Supply Current | PSRR $\mathrm{I}_{\mathrm{SY}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}= \pm 4.5 \mathrm{~V} \text { to } \pm 18 \mathrm{~V} \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{O}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=\infty \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \end{aligned}$ | $\begin{aligned} & 76 \\ & 76 \end{aligned}$ | $\begin{aligned} & 93 \\ & 93 \\ & 6.60 \\ & 6.70 \end{aligned}$ | $8$ | dB <br> dB <br> mA <br> mA |
| DYNAMIC PERFORMANCE <br> Slew Rate <br> Bandwidth <br> Bandwidth <br> Bandwidth <br> Differential Phase <br> Differential Gain | SR <br> BW <br> BW <br> BW | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=70 \mathrm{pF} \\ & -3 \mathrm{~dB}, \mathrm{C}_{\mathrm{L}}=20 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=\infty \\ & -3 \mathrm{~dB}, \mathrm{C}_{\mathrm{L}}=20 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega \\ & -3 \mathrm{~dB}, \mathrm{C}_{\mathrm{L}}=20 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=150 \Omega \\ & \mathrm{f}=3.58 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=150 \Omega \\ & \mathrm{f}=4.43 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=150 \Omega \\ & \mathrm{f}=3.58 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=150 \Omega \\ & \mathrm{f}=4.43 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=150 \Omega \end{aligned}$ |  | $\begin{aligned} & 2000 \\ & 100 \\ & 100 \\ & 100 \\ & 0.13 \\ & 0.15 \\ & 0.04 \\ & 0.06 \end{aligned}$ |  | V/us <br> MHz <br> MHz <br> MHz <br> Degrees <br> Degrees <br> \% <br> \% |
| NOISE PERFORMANCE Voltage Noise Density Current Noise Density | $\begin{aligned} & e_{n} \\ & i_{n} \end{aligned}$ | $\begin{aligned} & \mathrm{f}=1 \mathrm{kHz} \\ & \mathrm{f}=1 \mathrm{kHz} \end{aligned}$ |  | $4$ |  | $\begin{aligned} & \mathrm{nV} / \sqrt{\mathrm{Hz}} \\ & \mathrm{pA} / \sqrt{\mathrm{Hz}} \end{aligned}$ |

[^177]WAFER TEST LIMITS (@ $\mathrm{V}_{\mathrm{S}}= \pm 15.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)

| Parameter | Symbol | Conditions | Limit | Units |
| :---: | :---: | :---: | :---: | :---: |
| Offset Voltage | $\mathrm{V}_{\text {os }}$ | $\mathrm{V}_{\mathrm{s}}= \pm 15 \mathrm{~V}$ | 1 | mV max |
|  | $\mathrm{V}_{\text {os }}$ | $\mathrm{V}_{\mathrm{s}}= \pm 5 \mathrm{~V}$ | 2 | mV max |
| Input Bias Current | $\mathrm{I}_{\text {B }}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | 5 | $\mu \mathrm{A}$ max |
| Power Supply Rejection Ratio | PSRR | $\mathrm{V}= \pm 4.5 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | 76 |  |
| Output Voltage Range | $\mathrm{V}_{\mathrm{O}}$ | $\mathrm{R}_{\mathrm{L}}=150 \Omega$ | $\pm 10.5$ | $V$ min |
| Supply Current | $\mathrm{I}_{\text {SY }}$ | $\mathrm{V}_{\mathrm{O}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | 8.5 | mA max |
| Gain | $\mathrm{AV}_{\text {CL }}$ | $\mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | $1 \pm 0.005$ | V/V |

NOTE
Electrical tests and wafer probe to the limits shown. Due to variations in assembly methods and normal yield loss, yield after packaging is not guaranteed for standard product dice. Consult factory to negotiate specifications based on dice lot qualifications through sample lot assembly and testing.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

| Supply Voltage |  |
| :---: | :---: |
| Input Voltage | 8 V |
| Maximum Power Dissipation . . . . . . . . . . . . See Figure 16 |  |
| Storage Temperature Range |  |
| Z Package | $-65^{\circ} \mathrm{C}$ to $+175^{\circ} \mathrm{C}$ |
| P, S Package | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Operating Temperature Range |  |
| BUF04Z | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| BUF04S, P | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Junction Temperature Range |  |
| Z Package | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| P, S Package | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
|  | . . $+300^{\circ} \mathrm{C}$ |


| Package Type | $\boldsymbol{\theta}_{\mathbf{J A}^{2}}$ | $\boldsymbol{\theta}_{\mathbf{J C}}$ | Units |
| :--- | :---: | :---: | :---: |
| 8-Pin Cerdip (Z) | 148 | 16 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin Plastic DIP (P) | 103 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin SOIC (S) | 158 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTES

${ }^{1}$ Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
${ }^{2} \theta_{\mathrm{JA}}$ is specified for the worst case conditions, i.e., $\theta_{\mathrm{JA}}$ is specified for device in socket for cerdip, P-DIP, and LCC packages; $\theta_{J A}$ is specified for device soldered in circuit board for SOIC package.

## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| BUF04AZ/883 | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Cerdip | Q-8 |
| BUF04GP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Plastic DIP | N-8 |
| BUF04GS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | SO | SO-8 |
| BUF04GBC | $+25^{\circ} \mathrm{C}$ | DICE | DICE |

*For outline information see Package Information section.

DICE CHARACTERISTICS


BUF04 Die Size $0.075 \times 0.064$ inch, 5,280 Sq. Mils Substrate (Die Backside) is Connected to V+ Transistor Count 45.

## BUFO4-Typical Performance Characteristics



Figure 1. Input Offset Voltage ( $V_{\text {os }}$ ) Distribution (a $\pm 15 \mathrm{~V}, \mathrm{P}$-DIP


Figure 2. Input Offset Voltage ( $V_{O S}$ ) Distribution (a $\pm 5 \mathrm{~V}$, P-DIP


Figure 3. Input Offset Voltage $\left(V_{O S}\right)$ vs. Temperature


Figure 4. Input Offset Voltage ( $V_{o s}$ ) Distribution @ $\pm 15 \mathrm{~V}$, Cerdip


Figure 5. Input Offset Voltage ( $V_{\text {os }}$ ) Distribution @ $\pm 5 \mathrm{~V}$, Cerdip


Figure 6. Input Bias Current vs. Temperature


Figure 7. Supply Current vs. Temperature


Figure 8. Output Voltage Swing vs. Temperature @ $\pm 15$ V


Figure 9. Maximum Vout Swing vs. Load @ $\pm 5$ V


Figure 10. Output Impedance vs. Frequency


Figure 11. Output Voltage Swing vs. Temperature @ $\pm 5$ V


Figure 12. Maximum Vout Swing vs. Load @ $\pm 15$ V


Figure 13. Bias Current vs. Input Voltage


Figure 14. Power Supply Rejection vs. Frequency


Figure 15. Slew Rate vs. Temperature


Figure 16. Maximum Power Dissipation vs. Ambient Temperature


Figure 17. Input Noise Voltage vs. Frequency


Figure 18. Slew Rate vs. Capacitive Loads


Figure 19. Bandwidth and Phase vs. Capacitive Loads @ $\pm 5 \mathrm{~V}$


Figure 20. Bandwidth vs. Supply Voltage and Temperature


Figure 21. Gain and Phase Deviation, $R_{L}=150 \Omega$


Figure 22. Bandwidth \& Phase vs. Capacitive Loads (a) 15 V


Figure 23. Bandwidth vs. Loads


Figure 24. Gain and Phase Deviation, $R_{L}=2 k \Omega$


Figure 25. Small-Signal Transient Response


Figure 26. Large-Signal Transient Response


Figure 27. THD + Noise vs. Amplitude

## FUNCTIONAL DESCRIPTION

The BUF04 is a closed-loop voltage buffer based on a currentfeedback architecture. Its high open-loop transimpedance, high output current drive capability, and its low input offset voltage makes it useful in a variety of applications, such as buffering the inputs of sampling and flash $A / D$ converters, audio and video line drivers, active filters, and precision op amp boosters.
A transistor-level equivalent circuit for the BUF04 is illustrated in Figure 29. The input stage consists of a pair of emitterfollower transistors, Q1 and Q2, whose outputs drive a second set of transistors, Q3 and Q4. The emitters of Q3 and Q4 are connected together through diodes, D1 and D2, to form a lowimpedance input for the feedback signal (in current mode) from the output stage. The outputs of Q3 and Q4 are then "mirrored" to Q5 and Q6 which form the gain stage of the BUF04. The signal is taken from the collectors of Q5 and Q6 which drive a "Darlington-connected" output stage made up of transistors Q7-Q10. Three R-C networks (R1-C1, R2-C2, and R3-C3) form feed-forward paths which bypass certain sections of the BUF04 for improved high frequency performance and capacitive load drive capability. Since the signal conveyed internally in the BUF04 is a current, the frequency response and slew rate of the BUF04 are insensitive to supply voltage variations.


Figure 28. Bandwidth vs. Frequency


Figure 29. Transistor-Level Equivalent Circuit
An interesting feature of the BUF04 architecture is the use of "slew-enhancement" transistors, Q11-Q14. Under normal smallsignal ( $\mathrm{V}_{\mathrm{IN}}<2 \mathrm{~V}_{\mathrm{be}} \mathrm{s}$ ) conditions, these transistors are normally "OFF." In large signals, high speed transient applications where the input signal is $>2 \mathrm{~V}_{\mathrm{be}} \mathrm{s}$, these transistors turn on and literally "brute-force" the output to follow the input. When the input signal drops below $2 \mathrm{~V}_{\mathrm{be}} \mathrm{s}$, the transistors return to their normally "OFF" state.

A two-terminal equivalent circuit of the BUF04 is shown in Figure 30 where the transistor-level equivalent circuit is reduced to its essential elements. The input stage develops a signal current, $\mathrm{I}_{\mathrm{IN}}$, that is replicated by an internal current conveyor so as to flow through $R_{t}$, the transimpedance of the BUF04. The voltage developed across $R_{t}$ is buffered by a unity-gain output voltage follower. With an open-loop $R_{t}$ of $400 \mathrm{k} \Omega$ and an $R_{\text {IN }}$ of $30 \Omega$, the voltage gain of the BUF04, given by the ratio $R_{t} / R_{I N}$ is approximately 13,000 -accurate to approximately 13.5 bits. The BUF04's open-loop ac transimpedance response is determined by the open-loop pole formed by $R_{t}$ and $C_{t}$. Since $C_{t}$ is typically 8 pF , the open-loop pole occurs at approximately 50 kHz .


Figure 30. Current-Feedback Functional Equivalent Circuit of the BUF04

## Grounding and Bypassing Considerations

To take full advantage of the BUF04's very wide bandwidth, high slew rates, and dynamic range capabilities requires due diligence with regard to supply bypassing. In high speed circuits, the supply bypassing network must provide a very lowimpedance return path for currents flowing to and from the load network. As with any high speed application, multiple bypassing is always recommended. A $10 \mu \mathrm{~F}$ tantalum electrolytic in parallel with a $0.1 \mu \mathrm{~F}$ ceramic capacitor is sufficient for most applications. For those high speed applications where output load currents approach 50 mA , small-valued resistors ( $1.1 \Omega$ to $4.7 \Omega$ ) in series with the tantalum capacitors may improve circuit transient response by damping out the capacitor's selfinductance. Figure 31 illustrates bypassing recommendations.


Figure 31. Recommended Power-Supply Bypassing

To minimize the effects of high-frequency coupling, circuits must be built with short interconnect leads, and large ground planes should be used whenever possible to provide a low resistance, low-inductance circuit path. Sockets should be avoided because the increased interlead capacitance can degrade bandwidth and stability. If sockets are necessary, individual pin sockets (oftentimes called "cage jacks," AMP Part No. 5-330808-3 or $5-330808-6$ ) should be used. They contribute far less stray reactance than molded socket assemblies.

## Offset Voltage Nulling

Although the offset voltage of the BUF04 is very low ( 1 mV , maximum) for such a high speed buffer, the circuit shown in Figure 32 can be used if additional offset voltage nulling is required. A potentiometer ranging from 1 k to 10 k can be used for $\mathrm{V}_{\mathrm{Os}}$ nulling; with a $10 \mathrm{k} \Omega$ potentiometer, the trim range is $\pm 30 \mathrm{mV}$.


Figure 32. Optional Offset Voltage Nulling Scheme

## APPLICATIONS

## Output Short-Circuit Protection

To optimize the transient response and output voltage swing of the BUF04, internal output short-circuit current limiting was omitted. Although the BUF04 can provide continuous output currents of 50 mA without protection, direct connection of the BUF04's output to ground or to the supplies will destroy the device. An active current limit technique, illustrated in Figure 33 , provides the necessary short-circuit protection while retaining full dc output voltage swing to the load.


Figure 33. Short-Circuit Current Limiting Using Current Sources

## BUF04

## Output Current Transient Recovery

Settling characteristics of high speed buffers also include the buffer's ability to recover, i.e., settle, from a transient output current load condition. When driving the input of an A/D converter, especially the successive-approximation converter types, the buffer must maintain a constant output voltage under dynamically changing load current conditions. In these types of converters, the comparison point is usually diode-clamped, but it may deviate several hundred millivolts resulting in high frequency modulation of the $\mathrm{A} / \mathrm{D}$ input current. Open-loop and closed-loop buffers (also, op amps configured as followers) that exhibit high closed-loop output impedances and/or low unitygain crossover frequencies recover very slowly from output load current transients. This slow recovery leads to linearity errors or missing codes because of errors in the instantaneous input voltage. Therefore, the buffer (or op amp) chosen for this type of application should exhibit low output impedance and high unitygain bandwidth so that its output has had a chance to settle to its nominal value before the converter makes its comparison.
The circuit in Figure 34 illustrates a settling measurement circuit for evaluating the recovery time of high speed buffers from an output load current transient. The input to the buffer is grounded for ease of measuring the recovery time, and two resistors are used to sum steady-state and transient load currents at the output. As a worst-case condition, R1, was chosen such that the BUF04 would source (or sink) a steady-state current of 25 mA . R2 was then chosen to add a 10 mA transient current upon the steady-state value. To set accurately the nodal voltages internal to the BUF04, the supply voltages were offset by the voltage applied to R1. Because of its high transimpedance, wide bandwidth, and low output impedance, the BUF04 exhibits an extremely fast recovery time of 60 ns to $0.01 \%$, as shown in Figure 34. Results were identical regardless whether the BUF04 was sourcing or sinking current.


Figure 34. Transient Output Load Current Test Circuit


Figure 35. BUF04's Output Load Current Recovery Time

## Terminated Line Drivers

The BUF04's high output current, large slew rate, and wide bandwidth all combine to make it an ideal device for high speed line driver applications. As shown in Figure 36, the BUF04 can be configured for driving doubly terminated $50 \Omega$ and $75 \Omega$ cables. To optimize the circuit's pulse response, a capacitor, $\mathrm{C}_{\mathbf{T}}$ ( $\mathrm{C}_{\mathrm{x}}+\mathrm{C}_{\text {TRIM }}$ ), is connected across the series back termination. The BUF04 can drive a $50 \Omega$ line to $\pm 2.5 \mathrm{~V}$ and a $75 \Omega$ line to $\pm 3.75 \mathrm{~V}$ when operating on $\pm 15 \mathrm{~V}$ supplies.


Figure 36. Line Driver Configuration

## Low-Pass Active Filter

In many signal-conditioning applications, filters are required to band-limit noise or altogether eliminate other unwanted signals prior to conversion. Often, high frequency filters are needed for these applications; however, there are few op amps that exhibit the high open-loop gain and wide unity-gain crossover frequency required for these applications. As illustrated in Figure 37, the BUF04 and a handful of passive components can be configured as a high frequency, low-pass active filter. Since the filter configuration is a unity-gain Sallen-Key topology, the BUF04 is particularly well suited for this application. In this circuit, an additional resistor, R3, was added to prevent interaction between C2 and the BUF04's input capacitance.


Figure 37. A 10 MHz Low-Pass Active Filter

## Operation Within an Op Amp Feedback Loop

The BUF04 is well suited as a current booster or isolation buffer within the closed loop of precision op amps such as the OP177, the OP97, the OP27, or the OP77. Since the BUF04 is a closedloop voltage buffer, no interstage coupling resistor between the op amp and the buffer's input is required for circuit stability. The wide bandwidth and high slew rate of the BUF04 assure that the loop has the characteristics of the op amp; hence, no additional rolloff is required.


Figure 38. BUFO4 as Booster Stage for a Precision Op Amp

Paralleling BUF04s for Increased Load Drive Capability
In applications where continuous output currents greater than 50 mA are required or where heat management is an issue, a number of BUF04s can be connected in parallel to reduce the drive requirement of any one buffer. An example of one such application is illustrated in Figure 39. In this circuit, the BUF04s are required to drive a doubly terminated $50 \Omega$ line to $\pm 5 \mathrm{~V}$. This type of a load for a single BUF04 would certainly cause a power dissipation problem. Parallel operation results in lower input and output impedances and increased bias currents; on the other hand, input equivalent noise voltage is reduced and input offset voltage remains unchanged.


Figure 39. Paralleling BUF04s for High Output Currents

## Overdrive Recovery and Phase Reversal

In applications where the inputs could be driven to the supply rails, the BUF04 recovers in 10 ns from positive or negative overdrive. The BUF04 does not exhibit any output voltage phase reversal when the input signal exceeds its input voltage range.

## BUFO4





## FEATURES

- Low Vos . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 25 2 ${ }^{2} \mathrm{~V}$ Max
- Low Vos Drift $0.6 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ Max
- Ulitra-Stable vs Time $1.0 \mu \mathrm{~V} /$ Month Max
- Low Noise $0.6 \mu V_{\text {p-p }}$ Max
- Wide Input Voltage Range ............................. $\pm 14 \mathrm{~V}$
- Wide Supply Voltage Range $\ldots \ldots \ldots \ldots . . \pm 3 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$
- Fits 725, 108A/308A, 741, AD510 Sockets
- $125^{\circ}$ C Temperature-Tested Dice


## ORDERING INFORMATION ${ }^{\dagger}$

| $\begin{gathered} T_{A}=+25^{\circ} \mathrm{C} \\ \mathrm{~V}_{\text {os }} \mathrm{MAX} \end{gathered}$ <br> $(\mu \mathrm{V})$ | PACKAGE |  |  |  | OPERATING TEMPERATURE RANGE |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | TO-99 | CERDIP <br> 8-PIN | PLASTIC 8-PIN | $\frac{\text { LCC }}{\text { 20-CONTACT }}$ |  |
| 25 | OP07AJ* | OP07AZ* | - | - | MIL |
| 75 | OP07EJ | OP07EZ | OP07EP | - | COM |
| 75 | OP07J* | OP07Z* | - | OP07RC/883 | MIL |
| 150 | OP07CJ | OP07CZ | OP07CP | - | XIND |
| 150 | - | - | OP07CS ${ }^{\text {t }}$ | - | XIND |
| 150 | OP07DJ | - | OP07DP | - | XIND |

* For devices processed in total compliance to MIL-STD-883, add /883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.
tt For availability and burn-in information on SO and PLCC packages, contact your local sales office.


## GENERAL DESCRIPTION

The OP-07 has very low input offset voltage ( $25 \mu \mathrm{~V}$ max for OP-07A) which is obtained by trimming at the wafer stage. These low offset voltages generally eliminate any need for external nulling. The OP-07 also features low input bias current ( $\pm 2 \mathrm{nA}$ for OP-07A) and high open-loop gain ( $300 \mathrm{~V} / \mathrm{mV}$ for OP-07A). The low offsets and high open-loop gain make the OP-07 particularly useful for high-gain instrumentation applications.
The wide input voltage range of $\pm 13 \mathrm{~V}$ minimum combined with high CMRR of 110dB (OP-07A) and high input impedace provides high accuracy in the noninverting circuit configuration. Excellent linearity and gain accuracy can be maintained

## PIN CONNECTIONS



TO-99 (J-Suffix)




EPOXY MINI-DIP (P-Suffix)
8-PIN HERMETIC DIP
(Z-Suffix)
8-PIN SO
(S-Suffix)

OP-07RC/883
LCC
(RC-Suffix)
even at high closed-loop gains.
Stability of offsets and gain with time or variations in temperture is excellent. The accuracy and stability of the OP-07, even at high gain, combined with the freedom from external nulling have made the OP-07 a new industry standard for instrumentation and military applications.
The OP-07 is available in five standard performance grades. The OP-07A and the OP-07 are specified for operation over the full military range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$; the OP-07E is specified for operation over the $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ range, and OP-07C and D over the $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ temperature range.
The OP-07 is available in hermetically-sealed TO-99 metal can or ceramic 8 -pin Mini-DIP, and in epoxy 8 -pin Mini-DIP. It is a direct replacement for 725, 108A, and OP-05 amplifiers; 741-types may be directly replaced by removing the 741 's nulling potentiometer. The OP-207, a dual OP-07, is available for applications requiring close matching of two OP-07 amplifiers. For improved specifications, see the OP-77MP-177.

SIMPLIFIED SCHEMATIC


This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

| ABSOLUTE MAXIMUM RATINGS (Note 1) <br> Supply Voltage $\qquad$ |
| :---: |
| Differential Input Voltage .......................................................................30V |
| Input Voltage (Note 2) ............................................. $\pm 22 \mathrm{~V}$ |
| Output Short-Circuit Duration................................Indefinite |
| Storage Temperature Range |
| J, RC and Z Packages ......................... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| P Package ........................................ $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Operating Temperature Range |
| OP-07A, OP-07, OP-07RC .................... $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| OP-07E .............................................. $0^{\circ} \mathrm{C}$ to +7 |
|  |
| 俍 Temperature (Soldering, 60 sec ) ..................... $+300^{\circ} \mathrm{C}$ |
| nction Temperature ( $\mathrm{T}_{\mathrm{j}}$ ).................................... +15 |


| PACKAGE TYPE | $\boldsymbol{\Theta}_{\mathbf{I A}}$ (Note 3) | $\boldsymbol{\Theta}_{\mathbf{I C}}$ | UNITS |
| :--- | :---: | :---: | :---: |
| TO-99 (J) | 150 | 18 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8 -Pin Hermetic DIP (Z) | 148 | 16 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8 -Pin Plastic DIP (P) | 103 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 20-Contact LCC | 98 | 38 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8 -Pin SO $(\mathrm{S})$ | 158 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

NOTES:

1. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
2. For supply voltages less than $\pm 22 \mathrm{~V}$, the absolute maximum input voltage is equal to the supply voltage.
3. $\Theta_{j A}$ is specified for worst case mounting conditions, i.e., $\Theta_{j A}$ is specified for device in socket for TO, CerDIP, P-DIP, and LCC packages; $\Theta_{j A}$ is specified for device soldered to printed circuit board for SO package.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMB | CONDITIO | OP-07A |  |  | OP-07 |  |  | NITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PARAMETER | SVMBL | CONDITIONS | WIN |  |  | WH |  |  | NTS |
| Input Offset Voltage | $\mathrm{V}_{\mathrm{OS}}$ | (Note 1) | - | 10 | 25 | - | 30 | 75 | $\mu \mathrm{V}$ |
| Long-Term Input Offset Voltage Stability | $\Delta \mathrm{V}_{\text {OS }} /$ Time | (Note 2) | - | 0.2 | 1.0 | - | 0.2 | 1.0 | $\mu \mathrm{V} / \mathrm{Mo}$ |
| Input Offset Current | los |  | - | 0.3 | 2.0 | - | 0.4 | 2.8 | nA |
| Input Bias Current | $I_{B}$ |  | - | $\pm 0.7$ | $\pm 2.0$ | - | $\pm 1.0$ | $\pm 3.0$ | nA |
| Input Noise Voltage | $\theta_{\text {np-p }}$ | 0.1 Hz to 10 Hz (Note 3) | - | 0.35 | 0.6 | - | 0.35 | 0.6 | $\mu V_{p-p}$ |
| Input Noise Voltage Density | $e_{n}$ | $\begin{aligned} & f_{0}=10 \mathrm{~Hz}(\text { Note } 3) \\ & f_{0}=100 \mathrm{~Hz}(\text { Note } 3) \\ & f_{0}=1000 \mathrm{~Hz}(\text { Note } 3) \end{aligned}$ | - - - | $\begin{array}{r} 10.3 \\ 10.0 \\ 9.6 \end{array}$ | $\begin{aligned} & 18.0 \\ & 13.0 \\ & 11.0 \\ & \hline \end{aligned}$ | - | $\begin{array}{r} 10.3 \\ 10.0 \\ 9.6 \\ \hline \end{array}$ | $\begin{aligned} & 18.0 \\ & 13.0 \\ & 11.0 \end{aligned}$ | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| Input Noise Current | $i_{\text {npp-p }}$ | 0.1 Hz to 10 Hz (Note 3) | - | 14 | 30 | - | 14 | 30 | $p A_{p-p}$ |
| Input Noise Current Density | $i_{n}$ | $\begin{aligned} & f_{\mathrm{O}}=10 \mathrm{~Hz}(\text { Note } 3) \\ & \mathrm{f}_{\mathrm{O}}=100 \mathrm{~Hz}(\text { Note } 3) \\ & \mathrm{f}_{\mathrm{O}}=1000 \mathrm{~Hz} \text { (Note 3) } \end{aligned}$ | - | $\begin{aligned} & 0.32 \\ & 0.14 \\ & 0.12 \end{aligned}$ | $\begin{aligned} & 0.80 \\ & 0.23 \\ & 0.17 \end{aligned}$ | - | $\begin{aligned} & 0.32 \\ & 0.14 \\ & 0.12 \end{aligned}$ | $\begin{aligned} & 0.80 \\ & 0.23 \\ & 0.17 \end{aligned}$ | $\mathrm{pA} \sqrt{\mathrm{Hz}}$ |
| Input Resistance -Differential-Mode | $\mathrm{R}_{\mathbf{I N}}$ | (Note 4) | 30 | 80 | - | 20 | 60 | - | M |
| Input Resistance -Common-Mode | $\mathrm{R}_{\text {INCM }}$ |  | - | 200 | - | - | 200 | - | G $\Omega$ |
| Input Voltage Range | IVR |  | $\pm 13$ | $\pm 14$ | - | $\pm 13$ | $\pm 14$ | - | V |
| Common-Mode Rejection Ratio | CMRR | $\mathrm{V}_{\mathrm{CM}}= \pm 13 \mathrm{~V}$ | 110 | 126 | - | 110 | 126 | - | dB |
| Power Supply Rejection Ratio | PSRR | $\mathrm{V}_{\mathrm{S}}= \pm 3 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | 4 | 10 | - | 4 | 10 | $\mu \mathrm{V} / \mathrm{V}$ |
| Large-Signal Voltage Gain | Avo | $\begin{aligned} & R_{\mathrm{L}} \geq 2 \mathrm{k} \Omega, \mathrm{~V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{L}} \geq 500 \Omega, \mathrm{~V}_{\mathrm{O}}= \pm 0.5 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{S}}= \pm 3 \mathrm{~V} \text { (Note 4) } \end{aligned}$ | 300 150 | $\begin{array}{r} 500 \\ ' 400 \end{array}$ | - - | 200 150 | 500 400 | - | V/mV |
| Output Voltage Swing | $V_{0}$ | $\begin{aligned} & R_{L} \geq 10 \mathrm{k} \Omega \\ & R_{L} \geq 2 \mathrm{k} \Omega \\ & R_{L} \geq 1 \mathrm{k} \Omega \\ & \hline \end{aligned}$ | $\begin{aligned} & \pm 12.5 \\ & \pm 12.0 \\ & \pm 10.5 \end{aligned}$ | $\begin{aligned} & \pm 13.0 \\ & \pm 12.8 \\ & \pm 12.0 \end{aligned}$ | - | $\begin{aligned} & \pm 12.5 \\ & \pm 12.0 \\ & \pm 10.5 \end{aligned}$ | $\begin{aligned} & \pm 13.0 \\ & \pm 12.8 \\ & \pm 12.0 \end{aligned}$ | - | V |
| Slew Rate | SR | $\mathrm{R}_{\mathrm{L}} \geq \mathbf{2 k} \Omega$ (Note 3) | 0.1 | 0.3 | - | 0.1 | 0.3 | - | $\mathrm{V} / \mathrm{\mu s}$ |
| Closed-Loop Bandwidth | BW | $A_{\text {VCL }}=+1$ (Note 3) | 0.4 | 0.6 | - | 0.4 | 0.6 | - | MHz |
| Open-Loop Output Resistance | $\mathrm{R}_{0}$ | $v_{0}=0,1_{0}=0$ | - | 60 | - | - | 60 | - | $\Omega$ |
| Power Consumption | $P_{\text {d }}$ | $\begin{aligned} & V_{S}= \pm 15 \mathrm{~V}, \text { No Load } \\ & V_{\mathrm{S}}= \pm 3 \mathrm{~V}, \text { No Load } \end{aligned}$ | - | $\begin{array}{r} 75 \\ 4 \end{array}$ | $\begin{array}{r} 120 \\ 6 \end{array}$ | - | $\begin{array}{r} 75 \\ 4 \end{array}$ | 120 | mW |
| Offset Adjustment Range |  | $\mathrm{R}_{\mathrm{P}}=20 \mathrm{k} \Omega$ | - | $\pm 4$ | - | - | $\pm 4$ | - | mV |

## NOTES:

1. OP-07A grade $\mathrm{V}_{O S}$ is measured approximately one minute after apptication of power. For all other grades $\mathrm{V}_{\mathrm{OS}}$ is measured approximately 0.5 seconds after application of power.
2. Long-Term Input Offset Voltage Stability refers to the averaged trend line of $\mathbf{V}_{\mathbf{O s}} \mathbf{V s}$. Time over extended periods after the first $\mathbf{3 0}$ days of operation.

Excluding the initial hour of operation, changes in Vos during the first 30 operating days are typically $2.5 \mu \mathrm{~V}$ - refer to typical performance curves. Parameter is sample tested.
3. Sample tested.
4. Guaranteed by design.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V},-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | 8YMBOL | CONDITIONS | OP-07A |  |  | OP-07 |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input Offset Voltage | $V_{0 S}$ | (Note 1) | - | 25 | 60 | - | 60 | 200 | $\mu \mathrm{V}$ |
| Average Input Offset Voltage Drift Without External Trim | $\mathrm{TCV}_{\text {Os }}$ | (Note 2) | - | 0.2 | 0.6 | - | 0.3 | 1.3 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| With External Trim | $\mathrm{TCV}_{\text {OSn }}$ | $\mathrm{R}_{\mathrm{P}}=20 \mathrm{k} \Omega$ (Note 3) | - | 0.2 | 0.6 | - | 0.3 | 1.3 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current | los |  | - | 0.8 | 4 | - | 1.2 | 5.6 | nA |
| Average Input Offset Current Drift | $\mathrm{TCl}_{\text {OS }}$ | (Note 2) | - | 5 | 25 | - | 8 | 50 | PA ${ }^{\circ} \mathrm{C}$ |
| Input Bias Current | $I_{B}$ |  | - | $\pm 1$ | $\pm 4$ | - | $\pm 2$ | $\pm 6$ | nA |
| Average Input Bias Current Drift | $\mathrm{TCl}_{\mathrm{B}}$ | (Note 2) | - | 8 | 25 | - | 13 | 50 | pA ${ }^{\circ} \mathrm{C}$ |
| Input Voltage Range | IVR |  | $\pm 13$ | $\pm 13.5$ | - | $\pm 13$ | $\pm 13.5$ | - | V |
| Common-Mode Rejection Ratio | CMRR | $V_{\text {CM }}= \pm 13 \mathrm{~V}$ | 106 | 123 | - | 106 | 123 | - | dB |
| Power Supply Rejection Ratio | PSRR | $V_{S}= \pm 3 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | 5 | 20 | - | 5 | 20 | $\mu \mathrm{V} / \mathrm{N}$ |
| Large-Signal Voltage Gain | Avo | $\mathrm{R}_{\mathrm{L}} \geq 2 \mathrm{k} \Omega, \mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V}$ | 200 | 400 | - | 150 | 400 | - | $\mathrm{V} / \mathrm{mV}$ |
| Output Voltage Swing | $V_{0}$ | $\mathrm{R}_{\mathrm{L}} \geq \mathbf{2 k} \Omega$ | $\pm 12$ | $\pm 12.6$ | - | $\pm 12$ | $\pm 12.6$ | - | V |

NOTES:

1. OP-07A grade $V_{O S}$ is measured approximately one minute after application of power. For all other grades $\mathrm{V}_{\mathbf{O S}}$ is measured approximately 0.5 seconds after application of power.
2. Sample tested.
3. Guaranteed by design.

TYPICAL OFFSET VOLTAGE TEST CIRCUIT


OPTIONAL OFFSET NULLING CIRCUIT


TYPICAL LOW-FREQUENCY NOISE TEST CIRCUIT


BURN-IN CIRCUIT


PINOUTS SHOWN FOR J, P, AND Z PACKAGES

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.


## NOTES:

1. Input Offset Voltage measurements are performed by automated test equipment approximately 0.5 seconds after application of power.
2. Long-Term Input Offset Voltage Stability refers to the averaged trend line of $\mathrm{V}_{\mathbf{O S}} \mathrm{Vs}$. Time over extended periods after the first $\mathbf{3 0}$ days of operation.
Excluding the initial hour of operation, changes in $V_{\text {OS }}$ during the first 30 operating days are typically $2.5 \mu \mathrm{~V}$ - refer to typical performance curves. Parameter is sample tested.
3. Sample tested.
4. Guaranteed by design.
5. Guaranteed but not tested.

ELECTRICAL CHARACTERISTICS at $V_{S}= \pm 15 \mathrm{~V}, 0^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+70^{\circ} \mathrm{C}$ for OP-07E, and $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{A} \leq+85^{\circ} \mathrm{C}$ for $\mathrm{OP}-07 \mathrm{C} / \mathrm{D}$, unless otherwise noted.

|  |  |  | OP-07E |  |  | OP-07C |  |  | OP-07D |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PARAMETER | 8YMBOL | CONDITIONS |  |  | max | MIN | TY | max | MIN | TYP | MAX | UNIT8 |
| Input Offset Voltage | $V_{\text {OS }}$ | (Note 1) | - | 45 | 130 | - | 85 | 250 | - | 85 | 250 | $\mu \mathbf{V}$ |
| Average Input Offset |  |  |  |  |  |  |  |  |  |  |  |  |
| Voltage Drift Without External Trim | TCV ${ }_{\text {os }}$ | (Note 3) | - | 0.3 | 1.3 | - | 0.5 | 1.8 | - | 0.7 | 2.5 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| With External Trim | $\mathrm{TCV}_{\text {OSn }}$ | $\mathrm{R}_{\mathrm{P}}=20 \mathrm{k} \Omega$ (Note 3) | - | 0.3 | 1.3 | - | 0.4 | 1.6 | - | 0.7 | 2.5 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current | los |  | - | 0.9 | 5.3 | - | 1.6 | 8.0 | - | 1.6 | 8.0 | nA |
| Average Input Offset Current Drift | $\mathrm{TCl}_{\text {OS }}$ | (Note 2) | - | 8 | 35 | - | 12 | 50 | - | 12 | 50 | $\mathrm{pA}{ }^{\circ} \mathrm{C}$ |
| Input Bias Current | $I_{B}$ |  | - | $\pm 1.5$ | $\pm 5.5$ | - | $\pm 2.2$ | $\pm 9.0$ | - | $\pm 3.0$ | $\pm 14$ | $n A$ |
| Average Input Bias Current Drift | $\mathrm{TCl}_{\mathrm{B}}$ | (Note 2) | - | 13 | 35 | - | 18 | 50 | - | 18 | 50 | pA ${ }^{\circ} \mathrm{C}$ |
| Input Voltage Range | IVR |  | $\pm 13.0$ | $\pm 13.5$ | - | $\pm 13.0$ | $\pm 13.5$ | - | $\pm 13.0$ | $\pm 13.5$ | - | V |
| Common-Mode Rejection Ratio | CMRR | $V_{C M}= \pm 13 \mathrm{~V}$ | 103 | 123 | - | 97 | 120 | - | 94 | 106 | - | dB |
| Power Supply Rejection Ratio | PSRR | $V_{S}= \pm 3 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | 7 | 32 | - | 10 | 51 | - | 10 | 51 | $\mu \mathrm{V} / \mathrm{V}$ |
| Large-Signal Voltage Gain | Avo | $\begin{aligned} & \mathrm{R}_{\mathrm{L}} \geq \mathbf{2 k} \Omega \\ & \mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \\ & \hline \end{aligned}$ | 180 | 450 | - | 100 | 400 | - | 100 | 400 | - | V/mV |
| Output Voltage Swing | $v_{0}$ | $\mathrm{R}_{\mathrm{L}} \geq \mathbf{2 k} \boldsymbol{\Omega}$ | $\pm 12$ | $\pm 12.6$ | - | $\pm 11$ | $\pm 12.6$ | - | $\pm 11$ | $\pm 12.6$ | - | V |

NOTE8:

1. Input offset voltage measurements are performed by automated test equipment approximately 0.5 seconds after application of power.
2. Sample tested.
3. Guaranteed by design.

## FEATURES

- Low Noise . . . . . . . . . . . . . . . . . . . . . . 80nV $\mathrm{p}_{\mathrm{p}-\mathrm{p}}$ ( 0.1 Hz to 10 Hz )
$\qquad$
- Low Drift $0.2 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$
- High Speed . . . . . . . . . . . . . . . . . . . . . . . . $2.8 \mathrm{~V} / \mu$ s Slew Rate . .................................... . . . 8MHz Gain Bandwidth
- Low Vos
- High Open-Loop Gain ........................ . 1.8 Million
- Fits 725, OP-07, OP-05, AD510, AD517, 5534A sockets
- Available in Die Form


## ORDERING INFORMATION ${ }^{\dagger}$

| $\begin{gathered} \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ \mathrm{~V}_{\mathrm{OS}} \mathrm{MAXX} \\ (\mu \mathrm{~V}) \end{gathered}$ | PACKAGE |  |  |  | OPERATING TEMPERATURE RANGE |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | TO-99 | $\begin{aligned} & \text { CERDIP } \\ & \text { 8-PIN } \end{aligned}$ | PLASTIC 8-PIN | $\begin{gathered} \text { LCC } \\ \text { 20-CONTACT } \end{gathered}$ |  |
| 25 | OP27AJ* | OP27AZ* | - | - | MIL |
| 25 | OP27EJ | OP27EZ | OP27EP | - | IND/COM |
| 60 | OP27BJ* | OP27BZ* | - | OP27BR/883 | MIL |
| 60 | OP27FJ | OP27FZ | OP27FP | - | IND/COM |
| 100 | OP27CJ | OP27CZ | - | - | MIL |
| 100 | OP27GJ | OP27GZ | OP27GP | - | XIND |
| 100 | - | - | OP27Gs ${ }^{\dagger}$ | - | XIND |

* For devices processed in total compliance to MIL-STD-883, add /883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.
tt For availability and burn-in information on SO and PLCC packages, contact your local sales office.


## GENERAL DESCRIPTION

The OP-27 precision operational amplifier combines the low offset and drift of the OP-07 with both high speed and low noise. Offsets down to $25 \mu \mathrm{~V}$ and drift of $0.6 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ maximum make the OP-27 ideal for precision instrumentation applications. Exceptionally low noise, $e_{n}=3.5 \mathrm{nV} / \sqrt{\mathrm{Hz}}$, at 10 Hz , a low $1 / f$ noise corner frequency of 2.7 Hz , and high gain ( 1.8 million), allow accurate high-gain amplification of low-level
signals. A gain-bandwidth product of 8 MHz and a $2.8 \mathrm{~V} / \mu \mathrm{sec}$ slew rate provides excellent dynamic accuracy in high-speed data-acquisition systems.

A low input bias current of $\pm 10 n A$ is achieved by use of a bias-current-cancellation circuit. Over the military temperature range, this circuit typically holds $I_{B}$ and $I_{O S}$ to $\pm 20 \mathrm{nA}$ and 15 nA respectively.
The output stage has good load driving capability. A guaranteed swing of $\pm 10 \mathrm{~V}$ into $600 \Omega$ and low output distortion make the OP-27 an excellent choice for professional audio applications.
PSRR and CMRR exceed 120 dB . These characteristics, coupled with long-term drift of $0.2 \mu \mathrm{~V} /$ month, allow the circuit designer to achieve performance levels previously attained only by discrete designs.

## PIN CONNECTIONS



TO-99 (J-Suffix)
ن



8-PIN HERMETIC DIP (Z-Suffix)
EPOXY MINI-DIP (P-Suffix)
8-PIN SO (S-Suffix)

## OP-27BRC/883

LCC PACKAGE

## SIMPLIFIED SCHEMATIC



[^178]
## OP27

Low cost, high-volume production of OP-27 is achieved by using an on-chip zener-zap trimming network. This reliable and stable offset trimming scheme has proved its effectiveness over many years of production history.
The OP-27 provides excellent performance in low-noise high-accuracy amplification of low-level signals. Applications include stable integrators, precision summing amplifiers, precision voltage-threshold detectors, comparators, and professional audio circuits such as tape-head and microphone preamplifiers.
The OP-27 is a direct replacement for 725, OP-06, OP-07 and OP-05 amplifiers; 741 types may be directly replaced by removing the 741's nulling potentiometer.

## ABSOLUTE MAXIMUM RATINGS (Note 4)

Supply Voltage ................................................................. $\pm 22 \mathrm{~V}$
Input Voltage (Note 1) ....................................................... 土22V
Output Short-Circuit Duration ................................... Indefinite
Differential Input Voltage (Note 2) ................................... $\pm 0.7 \mathrm{~V}$
Differential Input Current (Note 2) ................................ $\pm 25 \mathrm{~mA}$
Storage Temperature Range ........................ $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

Operating Temperature Range
OP-27A, OP-27B, OP-27C (J, Z, RC) ........ $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ OP-27E, OP-27F (J, Z) ................................ $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ OP-27E, OP-27F (P) ........................................ $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ OP-27G (P, S, J, Z) ...................................... $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ Lead Temperature Range (Soldering, 60 sec ) $\qquad$ $300^{\circ} \mathrm{C}$ Junction Temperature $\qquad$ $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

| PACKAGE TYPE | $\Theta_{\text {1 }}$ (Note 3) | $\Theta_{\text {Ic }}$ | UNITS |
| :---: | :---: | :---: | :---: |
| TO-99 (J) | 150 | 18 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin Hermetic DIP (Z) | 148 | 16 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin Plastic DIP (P) | 103 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 20-Contact LCC (RC) | 98 | 38 | ${ }^{\circ} \mathrm{CW}$ |
| 8 -Pin SO (S) | 158 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

NOTES:

1. For supply voltages less than $\pm 22 \mathrm{~V}$, the absolute maximum input voltage is equal to the supply voltage.
2. The OP-27's inputs are protected by back-to-back diodes. Current limiting resistors are not used in order to achieve low noise. If differential input voltage exceeds $\pm 0.7 \mathrm{~V}$, the input current should be limited to 25 mA .
3. $\Theta_{j A}$ is specified for worst case mounting conditions, i.e., $\boldsymbol{\Theta}_{\mathrm{j} A}$ is specified for device in socket for TO, CerDIP, P-DIP, and LCC packages; $\boldsymbol{\theta}_{\mathrm{jA}}$ is specified for device soldered to printed circuit board for SO package.
4. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-27A/E |  |  | OP-27B/F |  |  | OP-27C/G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Input Offset Voltage | $\mathrm{V}_{\text {OS }}$ | (Note 1) | - | 10 | 25 | - | 20 | 60 | - | 30 | 100 | $\mu \mathrm{V}$ |
| Long-Term $\mathrm{V}_{\mathrm{OS}}$ Stability | $\mathrm{V}_{\text {os }} /$ Time | (Notes 2, 3) | - | 0.2 | 1.0 | - | 0.3 | 1.5 | - | 0.4 | 2.0 | $\mu \mathrm{V} / \mathrm{Mo}$ |
| Input Offset Current | los |  | - | 7 | 35 | - | 9 | 50 | - | 12 | 75 | nA |
| Input Bias Current | $I_{B}$ |  | - | $\pm 10$ | $\pm 40$ | - | $\pm 12$ | $\pm 55$ | - | $\pm 15$ | $\pm 80$ | $n A$ |
| Input Noise Voltage | $e_{\text {np-p }}$ | 0.1 Hz to 10 Hz (Notes 3, 5) | - | 0.08 | 0.18 | - | 0.08 | 0.18 | - | 0.09 | 0.25 | $\mu \mathrm{Vp}$-p |
| Input Noise Voltage Density | $e_{n}$ | $\begin{aligned} f_{\mathrm{O}} & =10 \mathrm{~Hz}(\text { Note } 3) \\ \mathrm{f}_{\mathrm{O}} & =30 \mathrm{~Hz}(\text { Note } 3) \\ f_{\mathrm{O}} & =1000 \mathrm{~Hz}(\text { Note } 3) \end{aligned}$ | - - - | $\begin{aligned} & 3.5 \\ & 3.1 \\ & 3.0 \end{aligned}$ | $\begin{aligned} & 5.5 \\ & 4.5 \\ & 3.8 \end{aligned}$ | - - - | 3.5 3.1 3.0 | $\begin{aligned} & 5.5 \\ & 4.5 \\ & 3.8 \end{aligned}$ | - | $\begin{aligned} & 3.8 \\ & 3.3 \\ & 3.2 \end{aligned}$ | $\begin{aligned} & 8.0 \\ & 5.6 \\ & 4.5 \end{aligned}$ | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| Input Noise Current Density | $i_{n}$ | $\begin{aligned} & f_{\mathrm{O}}=10 \mathrm{~Hz}(\text { Notes } 3,6) \\ & f_{\mathrm{O}}=30 \mathrm{~Hz}(\text { Notes } 3,6) \\ & f_{\mathrm{O}}=1000 \mathrm{~Hz}(\text { Notes } 3,6) \end{aligned}$ | - | $\begin{aligned} & 1.7 \\ & 1.0 \\ & 0.4 \end{aligned}$ | $\begin{aligned} & 4.0 \\ & 2.3 \\ & 0.6 \end{aligned}$ | - - - | 1.7 1.0 0.4 | $\begin{array}{r} 4.0 \\ 2.3 \\ 0.6 \end{array}$ | - - - | $\begin{aligned} & 1.7 \\ & 1.0 \\ & 0.4 \end{aligned}$ | - 0 | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
| Input Resistance -Differential-Mode | $\mathrm{R}_{\text {IN }}$ | (Note 7) | 1.3 | 6 | - | 0.94 | 5 | - | 0.7 | 4 | - | $\mathrm{M} \Omega$ |
| Input Resistance -Common-Mode | $\mathrm{R}_{\text {INCM }}$ |  | - | 3 | - | - | 2.5 | - | - | 2 | - | G $\Omega$ |
| Input Voltage Range | IVR |  | $\pm 11.0$ | $\pm 12.3$ | - | $\pm 11.0$ | $\pm 12.3$ | - | $\pm 11.0$ | $\pm 12.3$ | - | v |
| Common-Mode Rejection Ratio | CMRR | $\mathrm{V}_{\mathrm{CM}}= \pm 11 \mathrm{~V}$ | 114 | 126 | - | 106 | 123 | - | 100 | 120 | - | dB |
| Power Supply Rejection Ratio | PSRR | $V_{S}= \pm 4 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | - 1 | 10 | - | 1 | 10 | - | 2 | 20 | $\mu \mathrm{V} / \mathrm{V}$ |
| Large-Signal Voltage Gain | Avo | $\begin{aligned} & R_{\mathrm{L}} \geq 2 \mathrm{k} \Omega, \mathrm{~V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \\ & R_{\mathrm{L}} \geq 600 \Omega, \mathrm{~V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \end{aligned}$ | $\begin{array}{r} 1000 \\ 800 \\ \hline \end{array}$ | $\begin{aligned} & 1800 \\ & 1500 \\ & \hline \end{aligned}$ | - | $\begin{array}{r} 1000 \\ 800 \\ \hline \end{array}$ | $\begin{aligned} & 1800 \\ & 1500 \\ & \hline \end{aligned}$ | $-$ | $\begin{aligned} & 700 \\ & 600 \\ & \hline \end{aligned}$ | $\begin{aligned} & 1500 \\ & 1500 \\ & \hline \end{aligned}$ | - | V/mV |
| Output Voltage Swing | $\mathrm{V}_{0}$ | $\begin{aligned} & R_{L} \geq 2 k \Omega \\ & R_{L} \geq 600 \Omega \\ & \hline \end{aligned}$ | $\begin{aligned} & \pm 12.0 \\ & \pm 10.0 \end{aligned}$ | $\begin{array}{r}  \pm 13.8 \\ \pm 11.5 \end{array}$ | - | $\begin{aligned} & \pm 12.0 \\ & \pm 10.0 \end{aligned}$ | $\begin{aligned} & \pm 13.8 \\ & \pm 11.5 \end{aligned}$ | - | $\begin{aligned} & \pm 11.5 \\ & \pm 10.0 \end{aligned}$ | $\begin{aligned} & \pm 13.5 \\ & \pm 11.5 \end{aligned}$ | - | v |
| Slew Rate | SR | $\mathrm{R}_{\mathrm{L}} \geq 2 \mathrm{k} \Omega$ (Note 4) | 1.7 | 2.8 | - | 1.7 | 2.8 | - | 1.7 | 2.8 | - | $\mathrm{V} / \mu \mathrm{s}$ |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted. (Continued)

|  |  |  | OP-27A/E |  |  | OP-27B/F |  |  | OP-27C/G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Gain Bandwidth Prod. | GBW | (Note 4) | 5.0 | 8.0 | - | 5.0 | 8.0 | - | 5.0 | 8.0 | - | MHz |
| Open-Loop Output Resistance | $R_{0}$ | $\mathrm{V}_{\mathrm{O}}=0, \mathrm{I}_{0}=0$ | - | 70 | - | - | 70 | - | - | 70 | - | $\Omega$ |
| Power Consumption | $\mathrm{P}_{\mathrm{d}}$ | $\mathrm{v}_{\mathrm{O}}$ | - | 90 | 140 | - | 90 | 140 | - | 100 | 170 | mW |
| Offset Adjustment Range |  | $R_{P}=10 \mathrm{k} \Omega$ | - | $\pm 4.0$ | - | - | $\pm 4.0$ | - | - | $\pm 4.0$ | - | mV |

## NOTES:

1. Input offset voltage measurements are performed $\sim 0.5$ seconds after application of power. A/E grades guaranteed fully warmed-up.
2. Long-term input offset voltage stability refers to the average trend line of $V_{\text {OS }}$ vs. Time over extended periods after the first 30 days of operation. Excluding the initial hour of operation, changes in $\mathrm{V}_{\mathrm{OS}}$ during the first 30
days are typically $2.5 \mu \mathrm{~V}$ - refer to typical performance curve.
3. Sample tested.
4. Guaranteed by design.
5. See test circuit and frequency response curve for 0.1 Hz to 10 Hz tester.
6. See test circuit for current noise measurement.
7. Guaranteed by input bias current.

ELECTRICAL CHARACTERISTICS for $V_{S}= \pm 15 \mathrm{~V},-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-27A |  |  | OP-27B |  |  | OP-27C |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input Offset Voltage | $\mathrm{V}_{\mathrm{OS}}$ | (Note 1) | - | 30 | 60 | - | 50 | 200 | - | 70 | 300 | $\mu \mathrm{V}$ |
| Average Input Offset Drift | $\begin{aligned} & \mathrm{TCV}_{\mathrm{OS}} \\ & \mathrm{TCV}_{\mathrm{OSn}} \end{aligned}$ | (Note 2) <br> (Note 3) | - | 0.2 | 0.6 | - | 0.3 | 1.3 | - | 0.4 | 1.8 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current | los |  | - | 15 | 50 | - | 22 | 85 | - | 30 | 135 | nA |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ |  | - | $\pm 20$ | $\pm 60$ | - | $\pm 28$ | $\pm 95$ | - | $\pm 35$ | $\pm 150$ | nA |
| Input Voltage Range | IVR |  | $\pm 10.3$ | $\pm 11.5$ | - | $\pm 10.3$ | $\pm 11.5$ | - | $\pm 10.2$ | $\pm 11.5$ | - | v |
| Common-Mode Rejection Ratio | CMRR | $V_{C M}= \pm 10 \mathrm{~V}$ | 108 | 122 | - | 100 | 119 | - | 94 | 116 | - | dB |
| Power Supply Rejection Ratio | PSRR | $V_{S}= \pm 4.5 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | 2 | 16 | - | 2 | 20 | - | 4 | 51 | $\mu \mathrm{V} / \mathrm{V}$ |
| Large-Signal Voltage Gain | Avo | $R_{L} \geq 2 \mathrm{k} \Omega, \mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V}$ | 600 | 1200 | - | 500 | 1000 | - | 300 | 800 | . - | V/mV |
| Output Voltage Swing | $\mathrm{V}_{0}$ | $\mathrm{R}_{\mathrm{L}} \geq \mathbf{2 k}$ / | $\pm 11.5$ | $\pm 13.5$ | - | $\pm 11.0$ | $\pm 13.2$ | - | $\pm 10.5$ | $\pm 13.0$ | - | V |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{S}= \pm 15 \mathrm{~V},-25^{\circ} \mathrm{C} \leq T_{A} \leq+85^{\circ} \mathrm{C}$ for OP-27J and OP-27Z, $0^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+70^{\circ} \mathrm{C}$ for OP-27EP, FP and $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{A} \leq+85^{\circ} \mathrm{C}$ for OP-27GP, GS, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-27E |  |  | OP-27F |  |  | OP-27G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Input Offset Voltage | $\mathrm{V}_{\text {OS }}$ |  | - | 20 | 50 | - | 40 | 140 | - | 55 | 220 | $\mu \mathrm{V}$ |
| Average Input Offset Drift | TCV ${ }_{\text {OS }}$ <br> $\mathrm{TCV}_{\mathrm{OSn}}$ | (Note 2) <br> (Note 3) | - | 0.2 | 0.6 | - | 0.3 | 1.3 | - | 0.4 | 1.8 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current | los |  | - | 10 | 50 | - | 14 | 85 | - | 20 | 135 | $n A$ |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ |  | - | $\pm 14$ | $\pm 60$ | - | $\pm 18$ | $\pm 95$ | - | $\pm 25$ | $\pm 150$ | nA |
| Input Voltage Range | IVR |  | $\pm 10.5$ | $\pm 11.8$ | - | $\pm 10.5$ | $\pm 11.8$ | - | $\pm 10.5$ | $\pm 11.8$ | - | V |
| Common-Mode Rejection Ratio | CMRR | $V_{C M}= \pm 10 \mathrm{~V}$ | 110 | 124 | - | 102 | 121 | - | 96 | 118 | - | dB |
| Power Supply Rejection Ratio | PSRR | $V_{S}= \pm 4.5 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | 2 | 15 | - | 2 | 16 | - | 2 | 32 | $\mu \mathrm{V} / \mathrm{V}$ |
| Large-Signal Voltage Gain | Avo | $\mathrm{R}_{\mathrm{L}} \geq 2 \mathrm{k} \Omega, \mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V}$ | 750 | 1500 | - | 700 | 1300 | - | 450 | 1000 | - | V/mV |
| Output Voltage Swing | $\mathrm{V}_{0}$ | $\mathrm{R}_{\mathrm{L}} \geq \mathbf{2 k} \boldsymbol{\sim}$ | $\pm 11.7$ | $\pm 13.6$ | - | $\pm 11.4$ | $\pm 13.5$ | - | $\pm 11.0$ | $\pm 13.3$ | - | V |
| NOTES: <br> 1. Input offset volt equipment approx grades guarante | ge measu ximately 0 d fully war | ments are performe seconds after appli ed-up. |  | ated te wer. A/ |  | $\mathrm{TCV}_{0}$ ed with ple tes rantee | perform $R_{p}=8 i$ <br> d for B <br> by desi | ce is <br> to 20 <br> /F/G g | he sp $V_{O S}$ is | ification 100\% tes | unnull for | or when grades, |

DICE CHARACTERISTICS


DIE SIZE $0.109 \times 0.055$ inch, 5995 sq. mils ( $\mathbf{2 . 7 7} \times \mathbf{1 . 4 0 \mathrm { mm } , 3 . 8 8 \mathbf { s q } . \mathrm { mm } \text { ) } ) ~}$

1. NULL
2. (-) INPUT
3. (+) INPUT
4. $v-$
5. OUTPUT
6. $\mathbf{V}+$
7. NULL

WAFER TEST LIMITS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ for OP-27N, OP-27G, and OP-27GR devices; $\mathrm{T}_{\mathrm{A}}=125^{\circ} \mathrm{C}$ for OP-27NT and OP-27GT devices, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-27NT LIMIT | OP-27N LIMIT | OP-27GT <br> LIMIT | OP-27G LIMIT | OP-27GR <br> LIMIT | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input Offset Voltage | $\mathrm{V}_{\mathrm{OS}}$ | (Note 1) | 60 | 35 | 200 | 60 | 100 | $\mu \mathrm{V}$ MAX |
| Input Offset Current | los |  | 50 | 35 | 85 | 50 | 75 | nA MAX |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ |  | $\pm 60$ | $\pm 40$ | $\pm 95$ | $\pm 55$ | $\pm 80$ | nA MAX |
| Input Voltage Range | IVR |  | $\pm 10.3$ | $\pm 11$ | $\pm 10.3$ | $\pm 11$ | $\pm 11$ | $V$ MIN |
| Common-Mode Rejection Ratio | CMRR | $V_{C M}=1 V R$ | 108 | 114 | 100 | 106 | 100 | dB MIN |
| Power Supply Rejection Ratio | PSRR | $\mathrm{V}_{S}= \pm 4 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | 10 | - | 10 | 20 | $\mu \mathrm{V} / \mathrm{V}$ MAX |
| Large-Signal Voltage Gain | $A_{\text {vo }}$ | $\begin{aligned} & R_{L} \geq 2 \mathrm{k} \Omega, V_{O}= \pm 10 \mathrm{~V} \\ & R_{L} \geq 600 \Omega, V_{O}= \pm 10 \mathrm{~V} \\ & \hline \end{aligned}$ | 600 | $\begin{array}{r} 1000 \\ 800 \end{array}$ | 500 | $\begin{array}{r} 1000 \\ 800 \end{array}$ | $\begin{aligned} & 700 \\ & 600 \\ & \hline \end{aligned}$ | V/mV MIN |
| Output Voltage Swing | $\mathrm{V}_{0}$ | $\begin{aligned} & R_{L} \geq 2 \mathrm{k} \Omega \\ & R_{\mathrm{L}} \geq 600 \Omega \\ & \hline \end{aligned}$ | $\pm 11.5$ $-$ | $\begin{aligned} & \pm 12.0 \\ & \pm 10.0 \end{aligned}$ | $\pm 11.0$ | $\begin{aligned} & \pm 12.0 \\ & \pm 10.0 \end{aligned}$ | $\begin{aligned} & \pm 11.5 \\ & \pm 10.0 \end{aligned}$ | V MIN |
| Power Consumption | $\mathrm{P}_{\mathrm{d}}$ | $\mathrm{V}_{\mathrm{O}}=0$ | - | 140 | - | 140 | 170 | mW MAX |

NOTE:
Electrical tests are performed at wafer probe to the limits shown. Due to variations in assembly methods and normal yield loss, yield after packaging is not guaranteed for standard product dice. Consult factory to negotiate specifications based on dice lot qualification through sample lot assembly and testing.

TYPICAL ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-27N TYPICAL | OP-27G TYPICAL | OP-27GR TYPICAL | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Average Input Offset Voltage Drift | $\begin{aligned} & \mathrm{TCV}_{\mathrm{OS}} \text { or } \\ & \mathrm{TCV}_{\mathrm{OSn}} \end{aligned}$ | Nulled or Unnulled $R_{P}=8 \mathrm{k} \Omega$ to $20 \mathrm{k} \Omega$ | 0.2 | 0.3 | 0.4 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Average Input Offset Current Drift | $\mathrm{TCl}_{\text {os }}$ |  | 80 | 130 | 180 | $\mathrm{pA}{ }^{\circ} \mathrm{C}$ |
| Average Input Bias Current Drift | $\mathrm{TCl}_{\mathrm{B}}$ |  | 100 | 160 | 200 | $\mathrm{pA} /{ }^{\circ} \mathrm{C}$ |
| Input Noise Voltage Density | $e_{n}$ | $\begin{aligned} & f_{\mathrm{O}}=10 \mathrm{~Hz} \\ & f_{\mathrm{O}}=30 \mathrm{~Hz} \\ & f_{\mathrm{O}}=1000 \mathrm{~Hz} \end{aligned}$ | $\begin{aligned} & 3.5 \\ & 3.1 \\ & 3.0 \\ & \hline \end{aligned}$ | $\begin{aligned} & 3.5 \\ & 3.1 \\ & 3.0 \end{aligned}$ | $\begin{aligned} & 3.8 \\ & 3.3 \\ & 3.2 \\ & \hline \end{aligned}$ | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| Input Noise Current Density | $i_{n}$ | $\begin{aligned} & \mathrm{f}_{\mathrm{O}}=10 \mathrm{~Hz} \\ & \mathrm{f}_{\mathrm{O}}=30 \mathrm{~Hz} \\ & \mathrm{f}_{\mathrm{O}}=1000 \mathrm{~Hz} \end{aligned}$ | $\begin{aligned} & 1.7 \\ & 1.0 \\ & 0.4 \end{aligned}$ | $\begin{aligned} & 1.7 \\ & 1.0 \\ & 0.4 \\ & \hline \end{aligned}$ | $\begin{aligned} & 1.7 \\ & 1.0 \\ & 0.4 \\ & \hline \end{aligned}$ | $\mathrm{pA} \sqrt{\mathrm{Hz}}$ |
| Input Noise Voltage | $e_{n p-p}$ | 0.1 Hz to 10 Hz | 0.08 | 0.08 | 0.09 | $\mu \mathrm{Vp}$-p |
| Slew Rate | SR | $\mathrm{R}_{\mathrm{L}} \geq 2 \mathrm{k} \Omega$ | 2.8. | 2.8 | 2.8 | $\mathrm{V} / \mu \mathrm{s}$ |
| Gain Bandwidth Product | GBW |  | 8 | 8 | 8 | MHz |

## NOTE:

1. Input offset voltage measurements are performed by automated test equipment approximately 0.5 seconds after application of power.

# Low Noise, Precision, High Speed Operational Amplifier ( $\mathrm{AvcL}^{2} \geq 5$ ) 

## FEATURES

- Low Noise

80 nV p-p $(0.1 \mathrm{~Hz}$ to 10 Hz$)$ $3 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ at 1 kHz

- Low Drift $\qquad$
- High Speed . . . . . . . . . . . . . . . . . . . . . . . . . 17V/ $\mu$ s Slew Rate 63MHz Gain Bandwidth
- Low Input Offset Voltage ........................... $10 \mu \mathrm{~V}$
- Excellent CMRR ... 126dB (Common-Voltage of $\pm 11 \mathrm{~V}$ )
- High Open-Loop Gain ......................... 1.8 Million
- Replaces 725, OP-05, OP-06, OP-07, AD510, AD517, SE5534 in Gains > 5
- Available in Die Form


## ORDERING INFORMATION ${ }^{\dagger}$

| $\begin{gathered} \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ \mathrm{~V}_{\mathrm{OS}}^{(\mu \mathrm{MAX})} \end{gathered}$ | PACKAGE |  |  |  | OPERATING TEMPERATURE RANGE |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | T0-99 | CERDIP 8-PIN | PLASTIC 8-PIN | LCC <br> 20-CONTACT |  |
| 25 | OP37AJ* | OP37AZ* | - | - | MIL |
| 25 | OP37EJ | OP37EZ | OP37EP | - | IND/COM |
| 60 | OP37BJ* | OP37BZ* | - | OP37BRC/883 | MIL |
| 60 | OP37FJ | OP37FZ | OP37FP | - | IND/COM |
| 100 | OP37CJ* | OP37CZ | - | - | MIL |
| 100 | OP37GJ | OP37GZ | OP37GP | - | XIND |
| 100 | - | - | OP37GSt† | - | XIND |

* For devices processed in total compliance to MIL-STD-883, add /883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.
tt For availability and burn-in information on SO package, contact your local sales office.


## GENERAL DESCRIPTION

The OP-37 provides the same high performance as the OP-27, but the design is optimized for circuits with gains greater than five. This design change increases slew rate to $17 \mathrm{~V} / \mu \mathrm{sec}$ and gain-bandwidth product to 63 MHz .

## PIN CONNECTIONS



TO-99
(J-Suffix)




## OP-37BRC/883 <br> LCC PACKAGE <br> (RC-Suffix)

The OP-37 provides the low offset and drift of the OP-07 plus higher speed and lower noise. Offsets down to $25 \mu \mathrm{~V}$ and drift of $0.6 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ maximum make the OP-37 ideal for precision instrumentation applications. Exceptionally low noise $\left(e_{n}=3.5 n V / \sqrt{\mathrm{Hz}}\right.$ at 10 Hz ), a low $1 / f$ noise corner frequency of 2.7 Hz , and the high gain of 1.8 million, allow accurate high-gain amplification of low-level signals.
The low input bias current of $\pm 10 n A$ and offset current of $7 n A$ are achieved by using a bias-current-cancellation circuit. Over the military temperature range this typically holds $I_{B}$ and $I_{O S}$ to $\pm 20 \mathrm{nA}$ and 15 nA respectively.
The output stage has good load driving capability. A guaranteed swing of $\pm 10 \mathrm{~V}$ into $600 \Omega$ and low output distortion make the OP-37 an excellent choice for professional audio applications.


This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

PSRR and CMRR exceed 120dB. These characteristics, coupled with long-term drift of $0.2 \mu \mathrm{~V} /$ month; allow the circuit designer to achieve performance levels previously attained only by discrete designs.

Low-cost, high-volume production of the OP-37 is achieved by using on-chip zener-zap trimming. This reliable and stable offset trimming scheme has proved its effectiveness over many years of production history.
The OP-37 brings low-noise instrumentation-type performance to such diverse applications as microphone, tapehead, and RIAA phono preamplifiers, high-speed signal conditioning for data acquisition systems, and wide-bandwidth instrumentation.

## ABSOLUTE MAXIMUM RATINGS (Note 4)

Supply Voltage
Internal Voltage (Note 1) ....................................................土22V
Output Short-Circuit Duration .....................................Indefinite
Differential Input Voltage (Note 2) .................................... $\mathbf{0} .7 \mathrm{~V}$
Differential Input Current (Note 2) ..................................土25mA
Storage Temperature Range
$-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

Operating Temperature Range
OP-37A, OP-37B, OP-37C (J, Z, RC) ........ $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
OP-37E, OP-37F (J, Z) .................................. $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
OP-37E, OP-37F (P) ......................................... $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
OP-37G (P, S, J, Z) ....................................... $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Lead Temperature Range (Soldering, 60 sec ) ................ $300^{\circ} \mathrm{C}$ Junction Temperature ..................................... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

| PACKAGE TYPE | $\Theta_{\text {IA }}$ (NOTE 3) | $\theta_{\text {Ic }}$ | UNITS |
| :---: | :---: | :---: | :---: |
| TO-99 (J) | 150 | 18 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin Hermetic DIP (Z) | 148 | 16 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin Plastic DIP (P) | 103 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 20-Contact LCC (RC, TC) | 98 | 38 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin SO (S) | 158 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

1. For supply voltages less than $\pm 22 \mathrm{~V}$; the absolute maximum input voltage is equal to the supply voltage.
2. The OP-37's inputs are protected by back-to-back diodes. Current limiting resistors are not used in order to achieve low noise. If differential input voltagé exceeds $\pm 0.7 \mathrm{~V}$, the input current should be limited to 25 mA .
3. $\Theta_{j A}$ is specified for worst case mounting conditions, i.e., $\Theta_{j A}$ is specified for device in socket for TO, CerDIP, P-DIP, and LCC packages; $\Theta_{i A}$ is specified for device soldered to printed circuit board for SO package.
4. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.


ELECTRICAL CHARACTERISTICS at $V_{S}= \pm 15 \mathrm{~V}, T_{A}=25^{\circ} \mathrm{C}$, unless otherwise nofed. (Continued)

|  |  |  | OP-37A/E |  |  | OP-37B/F |  |  | OP-37C/G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | MIN | TYP. | MAX | MIN | TYP | MAX |  |
| Open-Loop Output Resistance | $\mathrm{R}_{\mathrm{O}}$ | $\mathrm{V}_{\mathrm{O}}=0.10=0$ | - | 70 | - | - | 70 | - | - | 70 | - | $\Omega$ |
| Power Consumption | $P_{d}$ | $\mathrm{V}_{\mathrm{O}}=0$ | - | 90 | 140 | - | 90 | 140 | - | 100 | 170 | mW |
| Offset Adjustment Range |  | $\mathrm{R}_{\mathrm{P}}=10 \mathrm{k} \Omega$ | - | $\pm 4.0$ | - | - | $\pm 4.0$ | - | - | $\pm 4.0$ | - | mV |

## NOTES:

1. Input offset voltage measurements are performed by automated test equipment approximately 0.5 seconds after application of power. $A / E$ grades guaranteed fully warmed up.
2. Long-term input offset voltage stability refers to the average trend line of $V_{\text {Os }}$ vs. Time over extended periods after the first 30 days of operation. Excluding the initial hour of operation, changes in $\mathrm{V}_{\text {OS }}$ during the first 30
days are typically $2.5 \mu \mathrm{~V}$ - refer to typical performance curve.
3. Sample tested.
4. Guaranteed by design.
5. See test circuit and frequency response curve for 0.1 Hz to 10 Hz tester.
6. See test circuit for current noise measurement.
7. Guaranteed by input bias current.

ELECTRICAL CHARACTERISTICS for $V_{S}= \pm 15 \mathrm{~V},-55^{\circ} \mathrm{C} \leq T_{A} \leq+125^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-37A |  |  | OP-37B |  |  | OP-37C |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input Offset Voltage | $\mathrm{V}_{\mathrm{OS}}$ | (Note 1) | - | 30 | 60 | - | 50 | 200 | - | 70 | 300 | $\mu \mathrm{V}$ |
| Average Input Offset Drift | $\begin{aligned} & \mathrm{TCV}_{\mathrm{OS}} \\ & \mathrm{TCV}_{\mathrm{OSn}} \\ & \hline \end{aligned}$ | (Note 2) <br> (Note 3) | - | 0.2 | 0.6 | - | 0.3 | 1.3 | - | 0.4 | 1.8 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current | los |  | - | 15 | 50 | - | 22 | 85 | - | 30 | 135 | nA |
| Input Bias Current | $I_{B}$ |  | - | $\pm 20$ | $\pm 60$ | - | $\pm 28$ | $\pm 95$ | - | $\pm 35$ | $\pm 150$ | nA |
| Input Voltage Range | IVR |  | $\pm 10.3$ | $\pm 11.5$ | - | $\pm 10.3$ | $\pm 11.5$ | - | $\pm 10.2$ | $\pm 11.5$ | - | V |
| Common-Mode <br> Rejection Ratio | CMRR | $\mathrm{V}_{\mathrm{CM}}= \pm 10 \mathrm{~V}$ | 108 | 122 | - | 100 | 119 | - | 94 | 116 | - | dB |
| Power Supply Rejection Ratio | PSRR | $V_{S}= \pm 4.5 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | 2 | 16 | - | 2 | 20 | - | 4 | 51 | $\mu \mathrm{V} / \mathrm{V}$ |
| Large-Signal Voltage Gain | Avo | $\mathrm{R}_{\mathrm{L}} \geq 2 \mathrm{k} \Omega, \mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V}$ | 600 | 1200 | - | 500 | 1000 | - | 300 | 800 | - | V/mV |
| Output Voltage Swing | $\mathrm{V}_{0}$ | $R_{L} \geq 2 k \Omega$ | $\pm 11.5$ | $\pm 13.5$ | - | $\pm 11.0$ | $\pm 13.2$ | - | $\pm 10.5$ | $\pm 13.0$ | - | V |

ELECTRICAL CHARACTERISTICS for $\mathrm{V}_{S}= \pm 15 \mathrm{~V},-25^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ for OP-37EJ/FJ and OP-37EZ/FZ, $0^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+70^{\circ} \mathrm{C}$ for OP-37EP/FP and $-40^{\circ} \mathrm{C} \leq T_{A} \leq+85^{\circ}$ for OP-37GP/GS/GJ/GZ, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-37E |  |  | OP-37F |  |  | OP-37G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Input Offset Voltage | $\mathrm{v}_{\text {OS }}$ |  | - | 20 | 50 | - | 40 | 140 | - | 55 | 220 | $\mu \mathrm{V}$ |
| Average Input Offset Drift | TCV ${ }_{\text {OS }}$ <br> TCV ${ }_{\text {OSn }}$ | (Note 2) <br> (Note 3) | - | 0.2 | 0.6 | - | 0.3 | 1.3 | - | 0.4 | 1.8 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current | los |  | - | 10 | 50 | - | 14 | 85 | - | 20 | 135 | $n \mathrm{~A}$ |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ |  | - | $\pm 14$ | $\pm 60$ | - | $\pm 18$ | $\pm 95$ | - | $\pm 25$ | $\pm 150$ | nA |
| Input Voltage Range | IVR |  | $\pm 10.5$ | $\pm 11.8$ | - | $\pm 10.5$ | $\pm 11.8$ | - | $\pm 10.5$ | $\pm 11.8$ | - | V |
| Common-Mode Rejection Ratio | CMRR | $V_{C M}= \pm 10 \mathrm{~V}$ | 110 | 124 | - | 102 | 121 | - | 96 | 118 | - | dB |
| Power Supply Rejection Ratio | PSRR | $\mathrm{V}_{\mathrm{S}}= \pm 4.5 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | 2 | 15 | - | 2 | 16 | - | 2 | 32 | $\mu \mathrm{V} / \mathrm{V}$ |
| Large-Signal Voltage Gain | Avo | $\mathrm{R}_{\mathrm{L}} \geq 2 \mathrm{k} \Omega, \mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V}$ | 750 | 1500 | - | 700 | 1300 | - | 450 | 1000 | - | V/mV |
| Output Voltage Swing | $\mathrm{V}_{0}$ | $\mathrm{R}_{\mathrm{L}} \geq 2 \mathrm{k} \Omega$ | $\pm 11.7$ | $\pm 13.6$ | - | $\pm 11.4$ | $\pm 13.5$ | - | $\pm 11.0$ | $\pm 13.3$ | - | v |
| NOTES: <br> 1. Input offset voltage measurements are performed by automated test equipment approximately 0.5 seconds after application of power. A/E grades guaranteed fully warmed up. |  |  |  |  | 2. The $T C V_{O s}$ performance is within the specifications unnulled or when nulled with $R_{P}=8 \mathrm{k} \Omega$ to $20 \mathrm{k} \Omega$. TCV ${ }_{\mathrm{OS}}$ is $100 \%$ tested for $A / E$ grades, sample tested for B/C/F/G grades. <br> 3. Guaranteed by design. |  |  |  |  |  |  |  |

## DICE CHARACTERISTICS

DIE SIZE $0.098 \times 0.056$ inch, 5488 sq. mils
( $2.49 \times 1.42 \mathrm{~mm}, \mathbf{3 . 5 4} \mathbf{~ s q} . \mathrm{mm}$ )


1. NULL
2. (-) INPUT
3. (+) INPUT
4. V-
5. OUTPUT
6. $\mathrm{V}+$
7. NULL

WAFER TEST LIMITS at $V_{S}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ for OP-37N, OP-37G and OP-37GR devices; $\mathrm{T}_{\mathrm{A}}=125^{\circ} \mathrm{C}$ for OP-37NT and OP-37GT devices, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-37NT LIMIT | OP-37N | $\begin{array}{r} \text { OP-37GT } \\ \text { LIMIT } \end{array}$ | OP-37G LIMIT | OP-37GR <br> LIMIT | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input Offset Voltage | $v_{\text {OS }}$ | (Note 1) | 60 | 35 | 200 | 60 | 100 | $\mu \mathrm{V}$ MAX |
| Input Offset Current | los |  | 50 | 35 | 85 | 50 | 75 | nA MAX |
| Input Bias Current | $I_{B}$ |  | $\pm 60$ | $\pm 40$ | $\pm 95$ | $\pm 55$ | $\pm 80$ | nA MAX |
| Input Voltage Range | IVR |  | $\pm 10.3$ | $\pm 11$ | $\pm 10.3$ | $\pm 11$ | $\pm 11$ | $V$ MIN |
| Common-Mode Rejection Ratio | CMRR | $\mathrm{V}_{\mathrm{CM}}= \pm 11 \mathrm{~V}$ | 108 | 114 | 100 | 106 | 100 | dB MIN |
| Power Supply Rejection Ratio | PSRR | $\begin{aligned} & T_{A}=25^{\circ} \mathrm{C}, V_{S}= \pm 4 \mathrm{~V} \text { to } \pm 18 \mathrm{~V} \\ & T_{A}=125^{\circ} \mathrm{C}, V_{S}= \pm 4.5 \mathrm{~V} \text { to } \pm 18 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 10 \\ & 16 \end{aligned}$ | $10$ | $\begin{aligned} & 10 \\ & 20 \end{aligned}$ | 10 | 20 | $\mu \mathrm{V} / \mathrm{V}$ MAX |
| Large-Signal Voltage Gain | Avo | $\begin{aligned} & R_{\mathrm{L}} \geq \mathbf{2 k} \Omega, V_{O}= \pm 10 \mathrm{~V} \\ & R_{\mathrm{L}} \geq \mathbf{1 k} \Omega, V_{O}= \pm 10 \mathrm{~V} \end{aligned}$ | 600 | $\begin{array}{r} 1000 \\ 800 \\ \hline \end{array}$ | 500 | $\begin{array}{r} 1000 \\ 800 \end{array}$ | 700 - | V/mV MIN |
| Output Voltage Swing | $V_{0}$ | $\begin{aligned} & R_{\mathrm{L}} \geq 2 \mathrm{k} \Omega \\ & R_{\mathrm{L}} \geq 600 \Omega \end{aligned}$ | $\pm 11.5$ - | $\begin{aligned} & \pm 12.0 \\ & \pm 10.0 \end{aligned}$ | $\pm 11.0$ - | $\begin{aligned} & \pm 12.0 \\ & \pm 10.0 \end{aligned}$ | $\begin{aligned} & \pm 11.5 \\ & \pm 10.0 \end{aligned}$ | V MIN |
| Power Consumption | $\mathrm{P}_{\mathrm{d}}$ | $\mathrm{V}_{\mathrm{O}}=0$ | - | 140 | - | 140 | 170 | mW MAX |

## NOTES:

For $25^{\circ}$ C characteristics of OP-37NT and OP-37GT devices, see OP-37N and
OP-37G characteristics, respectively.
Electrical tests are performed at wafer probe to the limits shown. Due to variations in assembly methods and normal yield loss, yield after packaging is not guaranteed for standard product dice. Consult factory to negotiate specifications based on dice lot qualification through sample lot asembly and testing.

TYPICAL ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-37NT TYPICAL | OP-37N TYPICAL | OP-37GT TYPICAL | OP-37G TYPICAL | OP-37GR TYPICAL | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Average Input Offset Voltage Drift | $\begin{aligned} & \mathrm{TCV}_{\mathrm{OS}} \text { or } \\ & \mathrm{TCV}_{\mathrm{OSn}} \end{aligned}$ | Nulled or Unnulled $R_{p}=8 \mathrm{k} \Omega \text { to } 20 \mathrm{k} \Omega$ | 0.2 | 0.2 | 0.3 | 0.3 | 0.4 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Average Input Offset Current Drift | TClos |  | 80 | 80 | 130 | 130 | 180 | $p N^{\circ} \mathrm{C}$ |
| Average Input Bias Current Drift | $\mathrm{TCl}_{\mathrm{B}}$ |  | 100 | 100 | 160 | 160 | 200 | $\mathrm{pA}{ }^{\circ} \mathrm{C}$ |
| Input Noise Voltage Density | $\boldsymbol{e}_{\boldsymbol{n}}$ | $\begin{aligned} & f_{\mathrm{O}}=10 \mathrm{~Hz} \\ & \mathrm{f}_{\mathrm{O}}=30 \mathrm{~Hz} \\ & \mathrm{f}_{\mathrm{O}}=1000 \mathrm{~Hz} \end{aligned}$ | $\begin{aligned} & 3.5 \\ & 3.1 \\ & 3.0 \end{aligned}$ | 3.5 <br> 3.1 <br> 3.0 | $\begin{aligned} & 3.5 \\ & 3.1 \\ & 3.0 \\ & \hline \end{aligned}$ | 3.5 3.1 3.0 | 3.8 <br> 3.3 <br> 3.2 | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| Input Noise Current Density | $i_{n}$ | $\begin{aligned} & f_{O}=10 \mathrm{~Hz} \\ & f_{0}=30 \mathrm{~Hz} \\ & f_{O}=1000 \mathrm{~Hz} \end{aligned}$ | $\begin{aligned} & 1.7 \\ & 1.0 \\ & 0.4 \end{aligned}$ | 1.7 <br> 1.0 <br> 0.4 | $\begin{array}{r} 1.7 \\ 1.0 \\ 0.4 \end{array}$ | 1.7 <br> 1.0 <br> 0.4 | 1.7 1.0 0.4 | $\mathrm{pA} \sqrt{\mathrm{Hz}}$ |
| Input Noise Voltage | $\theta_{\text {np-p }}$ | 0.1 Hz to 10 Hz | 0.08 | 0.08 | 0.08 | 0.08 | 0.09 | $\mu \mathrm{V}_{\mathrm{P}-\mathrm{P}}$ |
| Slew Rate | SR | $\mathrm{R}_{\mathrm{L}} \geq \mathbf{2 k} \boldsymbol{\Omega}$ | 17 | 17 | 17 | 17 | 17 | $\mathrm{V} / \mu \mathrm{s}$ |
| Gain Bandwidth Product | GBW | $\mathrm{f}_{\mathrm{O}}=10 \mathrm{kHz}$ | 63 | 63 | 63 | 63 | 63 | MHz |

## NOTE:

1. Input offset voltage measurements are performed by automated test
equipment approximately 0.5 seconds after application of power.

# High Speed, Fast Settling Precision Operational Amplifier 

## OP42

## FEATURES

## Fast

- Slew Rate 50V/ $\mu \mathrm{s}$ Min
- Settling-Time (0.01\%) 1 $\mu \mathrm{s}$ Max
- Gain-Bandwidth Product 10MHz Typ


## Precise

- Common-Mode Rejection .................................. 88dB Min
- Open-Loop Gain $500 \mathrm{~V} / \mathrm{mV}$ Min
- Offset Voltage $750 \mu \mathrm{~V}$ Max
- Bias Current 200pA Max


## Excellent Radiation Hardness

Available in Die Form

## ORDERING INFORMATION ${ }^{\dagger}$

|  | PACKAGE |  |  |  |  | OPERATING TEMPERATURE RANGE |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | TO-99 | $\begin{aligned} & \text { CERDIP } \\ & \text { 8-PIN } \end{aligned}$ | PLASTIC 8-PIN | $\begin{gathered} \text { SO } \\ \text { 8-PIN } \end{gathered}$ | $\begin{gathered} \text { LCC } \\ \text { 20-CONTACT } \end{gathered}$ |  |
| 1.0 | OP42A」* | OP42AZ* | - | - | OP42ARC/883 | 3 MIL |
| 0.75 | OP42EJ | OP42EZ | - | - | - | IND |
| 1.5 | OP42FJ | OP42FZ | - | - | - | IND |
| 5.0 | - | - | OP42GP | OP42GS | - | XIND |

* For devices processed in total compliance to MIL-STD-883, add /883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in cerdip, plastic dip, and TO-can packages.


## GENERAL DESCRIPTION

The OP-42 is a fast precision JFET-input operational amplifier. Similar in speed to the OP-17, the OP-42 offers a symmetric

PIN CONNECTIONS


20-CONTACT LCC (RC-Suffix)


(J-Suffix)

8-PIN CERDIP
(Z Suffix)
EPOXY MINI-DIP
(P-Suffix)
8-PIN SO
(S-Suffix)
$58 \mathrm{~V} / \mu \mathrm{s}$ slew rate and is internally compensated for unity-gain operation. OP-42 speed is achieved with a supply current of less than 6 mA . Unity-gain stability, a wide full-power bandwidth of 900 kHz , and a fast settling-time of 800 ns to $0.01 \%$ make the OP42 an ideal output amplifier for fast digital-to-analog converters.
Equal attention was given to both speed and precision in the OP42 design. Its tight $750 \mu \mathrm{~V}$ maximum input offset voltage combined with well-controlled drift of less than $10 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ eliminates the need for external nulling in many circuits. The OP-42's


[^179] complete data sheet, call our fax retrieval system at 1-800-446-6212.

GENERAL DESCRIPTION Continued
common-mode rejection of 88 dB minimum over a $\pm 11 \mathrm{~V}$ input voltage range is exceptional for a high-speed amplifier. High CMR combined with a minimum $500 \mathrm{~V} / \mathrm{mV}$ gain into $10 \mathrm{k} \Omega$ load ensure excellent linearity in both noninverting and inverting gain configurations. The low input bias and offset currents provided by the JFET input stage suit the OP-42 for use in high-speed sample and hold circuits, peak detectors, and log amplifiers. Excellent radiation hardness characteristics make the OP-42 ideal for military and aerospace applications.

The OP-42 conforms to the standard 741 pinout with nulling to V-. The OP-42 upgrades the performance of circuits using the AD544, AD611, AD711, and LF400 by direct replacement. In circuits without nulling, the OP-42 offers an upgrade for designs using the OP-16, OP-17, LT1022, LT1056, and HA2510.

ABSOLUTE MAXIMUM RATINGS (Note 1)


Storage Temperature Range
$-65^{\circ} \mathrm{C}$ to $+175^{\circ} \mathrm{C}$ Operating Temperature Range

| OP42A (J, Z) ........................................... $-55^{\circ} \mathrm{C}$ to +125 <br> OP42E, F (J, Z) ......................................... $-25^{\circ} \mathrm{C}$ to +85 |  |
| :---: | :---: |
|  |  |
|  |  |

$-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Junction Temperature ................................... $-65^{\circ} \mathrm{C}$ to $+175^{\circ} \mathrm{C}$
Lead Temperature Range (Soldering, 60 sec.) ........... $+300^{\circ} \mathrm{C}$

| PACKAGE TYPE | $\Theta_{\text {IA }}$ (NOTE 3) | $\boldsymbol{\theta}_{\text {IC }}$ | UNITS |
| :--- | :---: | :---: | :---: |
| TO-99 ( $J$ ) | 150 | 18 | ${ }^{\circ} \mathrm{C} / W$ |
| 8-Pin Hermetic DIP (Z) | 148 | 16 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin Plastic DIP (P) | 103 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 20-Contact LCC (RC,TC) | 98 | 38 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin SO (S) | 158 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| NOTES: |  |  |  |

1. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
2. For supply voltages less than $\pm 20 \mathrm{~V}$, the absolute maximum input voltage is equal to the supply voltage.
3. $\Theta_{j A}$ is specified for worst case mounting conditions, i.e., $\boldsymbol{\theta}_{j A}$ is specified for device in socket for TO, CERDIP, P-DIP, and LCC packages; $\theta_{j A}$ is specified for device soldered to printed circuit board for SO package.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{S}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-42E |  |  | OP-42F |  |  | OP-42G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Offset Voltage | $\mathrm{V}_{\text {OS }}$ |  | - | 0.3 | 0.75 | - | 0.4 | 1.5 | - | 1.5 | 5.0 | mV |
| Input Bias Current | $I_{B}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V} \mathrm{~T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ | - | 80 | 200 | - | 130 | 250 | - | 130 | 250 | pA |
| Input Offset Current | $\mathrm{I}_{\mathrm{os}}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ | - | 4 | 40 | - | 6 | 50 | - | 6 | 50 | pA |
| Input Voltage Range | IVR | (Note 1) | $\pm 11$ | $\begin{array}{r} +12.5 \\ -12.0 \end{array}$ | - | $\pm 11$ | $\begin{aligned} & +12.5 \\ & -12.0 \end{aligned}$ | - | $\pm 11$ | $\begin{array}{r} +12.5 \\ -12.0 \end{array}$ | - | V |
| Common-Mode Rejection | CMR | $V_{C M}= \pm 11 \mathrm{~V}$ | 88 | 98 | - | 80 | 92 | - | 80 | 92 | - | dB |
| Power-Supply Rejection Ratio | PSRR | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}= \pm 10 \mathrm{~V} \\ & \text { to } \pm 20 \mathrm{~V} \end{aligned}$ | - | 9 | 40 | - | 12 | 50 | - | 12 | 50 | $\mu \mathrm{V} / \mathrm{N}$ |
| Large-Signal Voltage Gain | Avo | $\begin{array}{ll} R_{L}=10 \mathrm{k} \Omega & V_{O}= \pm 10 \mathrm{~V} \\ R_{L}=2 \mathrm{k} \Omega & T_{j}=25^{\circ} \mathrm{C} \\ R_{L}=1 \mathrm{k} \Omega & \end{array}$ | $\begin{aligned} & 500 \\ & 200 \\ & 100 \end{aligned}$ | $\begin{aligned} & 900 \\ & 260 \\ & 170 \end{aligned}$ | - | $\begin{aligned} & 500 \\ & 200 \\ & 100 \end{aligned}$ | $\begin{aligned} & 900 \\ & 260 \\ & 170 \end{aligned}$ | - | 500 200 100 | $\begin{aligned} & 900 \\ & 260 \\ & 170 \end{aligned}$ | - | $\mathrm{V} / \mathrm{mV}$ |
| Output Voltage Swing | $V_{0}$ | $R_{L}=1 \mathrm{k} \Omega$ | $\pm 11.5$ | $\begin{array}{r} +12.5 \\ -11.9 \end{array}$ | - | $\pm 11.5$ | $\begin{aligned} & +12.5 \\ & -11.9 \end{aligned}$ | - | $\pm 11.5$ | $\begin{array}{r} +12.5 \\ -11.9 \end{array}$ | - | V |
| Short-Circuit Current Limit | Isc | Output Shorted to Ground | $\pm 20$ | $\begin{array}{r} +33 \\ +28 \\ \hline \end{array}$ | $\pm 60$ | $\pm 20$ | $\begin{array}{r} +33 \\ +28 \\ \hline \end{array}$ | $\pm 60$ | $\pm 20$ | $\begin{array}{r} +33 \\ -28 \\ \hline \end{array}$ | $\pm 60$ | mA |
| Supply Current | ${ }^{\prime} \mathrm{SY}$ | No Load $v_{0}=0 \mathrm{~V}$ | - | 5.1 | 6.0 | - | 5.1 | 6.5 | - | 5.1 | 6.5 | mA |
| Slew Rate | SR |  | 50 | 58 | - | 40 | 50 | - | 40 | 50 | - | $\mathrm{V} / \mathrm{\mu s}$ |
| Full-Power Bandwidth | $\mathrm{BW}_{\mathrm{p}}$ | (Note 2) | 750 | 900 | - | 600 | 800 | - | 600 | 800 | - | kHz |
| Gain-Bandwidth Product | GBW | $\mathrm{f}_{0}=10 \mathrm{kHz}$ | - | 10 | - | - | 10 | - | - | 10 | - | MHz |
| Setting -Time | $\mathrm{t}_{s}$ | 10V Step 0.01\% (Note 3) | - | 0.8 | 1.0 | - | 0.9 | 1.2 | - | 0.9 | 1.2 | $\mu \mathrm{s}$ |
| Overload Recovery Time | $t_{O R}$ |  | - | 700 | - | - | 700 | - | - | 700 | - | ns |
| Phase Margin | $\phi_{0}$ | Odb Gain | - | 47 | - | - | 47 | - | - | 47 | - | degrees |
| Gain Margin | $\mathrm{A}_{180}$ | $180^{\circ}$ Open-Loop Phase Shift | - | 9 | - | - | 9 | - | - | 9 | - | dB |
| Capacitive Load Drive Capability | $C_{L}$ | Unity-Gain Stable (Note 4) | 100 | 300 | - | 100 | 300 | - | 100 | 300 | - | pF |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted. Continued


ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{S}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | MIN | $\begin{gathered} \text { OP-42A } \\ \text { TYP } \end{gathered}$ | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Offset Voltage | $\mathrm{V}_{\text {os }}$ |  | - | 0.3 | 1.0 | mV |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ | $\mathrm{V}_{C M}=0 \mathrm{~V}_{1}=25^{\circ} \mathrm{C}$ | - | 80 | 200 | pA |
| Input Offiset Current | ${ }_{\text {los }}$ | $\mathrm{V}_{C M}=0 \mathrm{~V}_{1}=25^{\circ} \mathrm{C}$ | - | 4 | 40 | PA |
| Input Voltage Range | IVR | (Note 1) | $\pm 11$ | $\begin{aligned} & +12.5 \\ & -12.0 \end{aligned}$ | - | V |
| Common-Mode Rejection | CMR | $\mathrm{V}_{\mathrm{CM}}= \pm 11 \mathrm{~V}$ | 86 | 96 | - | dB |
| Power-Supply Rejection Ratio | PSRR | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}= \pm 10 \mathrm{~V} \\ & \text { to } \pm 20 \mathrm{~V} \end{aligned}$ | - | 9 | 40 | $\mu \mathrm{VN}$ |
| Large-Signal Voltage Gain | Avo | $\begin{array}{ll} R_{L}=10 \mathrm{k} \Omega & V_{0}= \pm 10 \mathrm{~V} \\ R_{\mathrm{L}}=2 \mathrm{k} \Omega & T_{1}=25^{\circ} \mathrm{C} \\ \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega & \end{array}$ | $\begin{aligned} & 500 \\ & 200 \\ & 100 \end{aligned}$ | $\begin{aligned} & 900 \\ & 260 \\ & 170 \end{aligned}$ | - | V/mV |
| Output Voltage Swing | $\mathrm{V}_{0}$ | $\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \boldsymbol{\Omega}$ | $\pm 11.5$ | $\begin{aligned} & \hline+12.5 \\ & -11.9 \end{aligned}$ | - | v |
| Short-Circuit Current Limit | ${ }_{\text {Isc }}$ | Output Shorted to Ground | $\pm 20$ | $\begin{array}{r} +33 \\ -28 \\ \hline \end{array}$ | $\pm 60$ | mA |
| Supply Current | Isy | $\begin{aligned} & \text { No Load } \\ & \mathrm{V}_{\mathrm{O}}=0 \mathrm{~V} \end{aligned}$ | - | 5.1 | 6.0 | mA |
| Slew Rate | SR |  | 45 | 52 | - | V/us |
| Full-Power Bandwidth | $\mathrm{BW}_{\mathrm{p}}$ | (Note 2) | 700 | 850 | - | kHz |
| Gain-Bandwidth Product | GBW | $\mathrm{f}_{0}=10 \mathrm{kHz}$ | - | 10 | - | MHz |
| Settling -Time | $t_{s}$ | $\begin{aligned} & \text { 10V Step 0.01\% } \\ & \text { (Note 3) } \\ & \hline \end{aligned}$ | - | 0.8 | 1.0 | $\mu s$ |
| Overload Recovery Time | ${ }_{\text {tor }}$ |  | - | 700 | - | ns |
| Phase Margin | $\dagger_{\circ}$ | Odb Gain | - | 47 | - | degrees |

## OP42

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted. Continued

| PARAMETER | SYMBOL | CONOITIONS | MIN | $\begin{aligned} & \text { OP-42A } \end{aligned}$ | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Gain Margin | $\mathrm{A}_{180}$ | $\begin{aligned} & 180^{\circ} \text { Open-Loop } \\ & \text { Phase Snift } \end{aligned}$ | - | 9 | - | dB |
| Capacitive Load Drive Capability | $C_{L}$ | Unity-Gain Stable (Note 4) | 100 | 300 | - | pF |
| Differential Input Impedance | $Z_{\text {IN }}$ |  | - | $10^{12}\| \| 6$ | - | Q $\\|_{\text {PF }}$ |
| Open-Loop Output Resistance | $\mathrm{R}_{0}$ |  | - | 50 | - | $\Omega$ |
| Voltage Noise | $e_{n p-p}$ | 0.1 Hz to 10 Hz | - | 2 | - | $\mu V_{p-p}$ |
| Voltage Noise Density | $\theta_{n}$ | $\begin{aligned} & \mathrm{f}_{\mathrm{O}}=10 \mathrm{~Hz} \\ & \mathrm{f}_{\mathrm{O}}=100 \mathrm{~Hz} \\ & \mathrm{f}_{\mathrm{O}}=1 \mathrm{kHz} \\ & \mathrm{f}_{\mathrm{O}}=10 \mathrm{kHz} \end{aligned}$ | - | 38 16 13 12 | - | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| Current Noise Density | $i_{n}$ | $\mathrm{f}_{\mathrm{o}}=1 \mathrm{kHz}$ | - | 0.007 | - | $\mathrm{pA} \sqrt{\mathrm{Hz}}$ |
| External $\mathrm{V}_{\mathrm{OS}}$ Trim Range |  | $\mathrm{R}_{\text {pot }}=\mathbf{2 0 k} \mathbf{\Omega}$ | - | 4 | - | mV |
| $\begin{aligned} & \text { Long-Term } \\ & \mathrm{V}_{\mathrm{OS}} \text { Drift } \end{aligned}$ |  |  | - | 5 | - | $\mu \mathrm{V} /$ month |
| Supply Voltage Range | $\mathrm{v}_{\text {S }}$ |  | $\pm 8$ | $\pm 15$ | $\pm 20$ | V |
| NOTES: <br> 1. Guaranteed by CMR <br> 2. Guaranteed by slew- | d formula B | $\boldsymbol{r l}_{10} \mathrm{~V}_{\text {PEAK }}$ ). | 3. Settling-time is sample tested for A and E grades. Test circuit is shown in Figure 4. Settling-time for F grade is guaranteed but not tested. <br> 4. Guaranteed but not tested. |  |  |  |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{S}= \pm 15 \mathrm{~V},-25^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq 85^{\circ} \mathrm{C}$ for $\mathrm{E} / \mathrm{F}$ grades, and $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ for G grade, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-42E |  |  | OP-42F |  |  | OP-42G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Offset Voltage | $\mathrm{V}_{\text {os }}$ |  | - | 0.4 | 1.2 | - | 0.6 | 2.5 | - | 2.0 | 6.0 | mV |
| Offset Voltage Temperature Coefficient | $\mathrm{TCV}_{\text {os }}$ |  | - | 4 | 10 | - | 8 | - | - | 8 | - | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ | (Note 1) | - | 0.5 | 1.2 | - | 0.6 | 2.0 | - | 0.6 | 2.0 | nA |
| Input Offset Current | Ios | (Note 1) | - | 0.05 | 0.2 | - | 0.06 | 0.4 | - | 0.06 | 0.4 | nA |
| Input Voltage Range | IVR | (Note 2) | $\pm 11$ | $\begin{aligned} & +12.5 \\ & -12.0 \end{aligned}$ | - | $\pm 11$ | $\begin{array}{r} \hline+12.5 \\ -12.0 \end{array}$ | - | $\pm 11$ | $\begin{aligned} & \hline+12.5 \\ & -12.0 \end{aligned}$ | - | v |
| Common-Mode Rejection | CMR | $\mathrm{V}_{\mathrm{CM}}= \pm 11 \mathrm{~V}$ | 86 | 96 | - | 80 | 94 | - | 80 | 94 | - | dB |
| Power-Supply Rejection Ratio | PSRR | $\begin{aligned} & \mathrm{V}_{\mathrm{s}}= \pm 10 \mathrm{~V} \\ & \text { to } \pm 20 \mathrm{~V} \end{aligned}$ | - | 2 | 40 | - | 6 | 50 | - | 6 | 50 | $\mu \mathrm{VN}$ |
| Large-Signal Voltage Gain | Avo | $\begin{aligned} & R_{L}=10 \mathrm{k} \Omega \quad(\text { Note } 1) \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \quad \mathrm{~V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \\ & \hline \end{aligned}$ | $\begin{aligned} & 200 \\ & 100 \\ & \hline \end{aligned}$ | $\begin{aligned} & 500 \\ & 160 \\ & \hline \end{aligned}$ | - | $\begin{aligned} & 200 \\ & 100 \end{aligned}$ | $\begin{aligned} & 500 \\ & 160 \\ & \hline \end{aligned}$ | - | $\begin{aligned} & 200 \\ & 100 \\ & \hline \end{aligned}$ | $\begin{aligned} & 500 \\ & 160 \\ & \hline \end{aligned}$ | - | V/mV |
| $\begin{aligned} & \text { Output Voltage } \\ & \text { Swing } \\ & \hline \end{aligned}$ | $\mathrm{V}_{0}$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | $\pm 11.0$ | $\begin{array}{r} +12.3 \\ -11.8 \\ \hline \end{array}$ | - | $\pm 11.0$ | $\begin{array}{r} +12.3 \\ -11.8 \\ \hline \end{array}$ | - | $\pm 11.0$ | $\begin{array}{r} +12.3 \\ -11.8 \\ \hline \end{array}$ | - | v |
| Short-Circuit Current Limit | Isc | Output Shorted to Ground | $\pm 8$ | - | $\pm 60$ | $\pm 8$ | - | $\pm 60$ | $\pm 8$ | - | $\pm 60$ | mA |
| Supply Current | $\mathrm{I}_{\mathrm{sY}}$ | No Load $v_{0}=0 \mathrm{~V}$ | - | 5.1 | 6.0 | - | 5.1 | 6.5 | - | 5.1 | 6.5 | mA |
| Slew Rate | SR | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | 45 | 57 | - | 40 | 50 | - | 40 | 50 | - | $\mathrm{V} / \mathrm{\mu s}$ |
| Capacitive Load Drive Capability | $\mathrm{C}_{\mathrm{L}}$ | Unity-Gain Stable (Note 3) | 100 | 250 | - | 100 | 250 | - | 100 | 250 | - | pF |

## NOTES:

1. $\mathrm{T}_{\mathrm{i}}=85^{\circ} \mathrm{C}$ for $\mathrm{E} / \mathrm{F} / \mathrm{G}$ Grades; $\mathrm{T}_{\mathrm{i}}=125^{\circ} \mathrm{C}$ for A grade.
2. Guaranteed by CMR test.
3. Guaranteed but not tested.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V},-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq 125^{\circ} \mathrm{C}$ for A grade, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-42A |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | max |  |
| Offset Voltage | $\mathrm{V}_{\text {os }}$ |  | - | 0.5 | 2.0 | mV |
| Offset Voltage Temperature Coefficient | TCV ${ }_{\text {os }}$ |  | - | 4 | 10 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ | (Note 1) | - | 6 | 20 | nA |
| Input Offiset Current | Ios | (Note 1) | - | 0.2 | 1.0 | nA |
| Input Voltage Range | IVR | (Note 2) | $\pm 11$ | $\begin{aligned} & \hline+12.5 \\ & -12.0 \end{aligned}$ | - | V |
| $\begin{aligned} & \text { Common-Mode } \\ & \text { Rejection } \\ & \hline \end{aligned}$ | CMR | $\mathrm{V}_{\mathrm{CM}}= \pm 11 \mathrm{~V}$ | 80 | 94 | - | dB |
| Power-Supply Rejection Ratio | PSRR | $\begin{aligned} & V_{\mathrm{s}}= \pm 10 \mathrm{~V} \\ & \text { to } \pm 20 \mathrm{~V} \end{aligned}$ | - | 10 | 50 | $\mu \mathrm{V} /$ |
| $\begin{gathered} \text { Large-Signal } \\ \text { Voltage Gain } \\ \hline \end{gathered}$ | Avo | $\begin{aligned} & R_{L}=10 \mathrm{k} \Omega \quad(\text { Note } 1) \\ & R_{L}=2 \mathrm{k} \Omega \quad V_{0}= \pm 10 \mathrm{~V} \end{aligned}$ | $\begin{array}{r} 160 \\ 80 \end{array}$ | $\begin{aligned} & 350 \\ & 110 \end{aligned}$ | - | V/mV |
| Output Voltage Swing | $v_{0}$ | $R_{L}=2 \mathrm{k} \Omega$ | $\pm 11.0$ | $\begin{aligned} & +12.3 \\ & -11.8 \end{aligned}$ | - | V |
| Short-Circuit Current Limit | 'sc | Output Shorted to Ground | $\pm 8$ | - | $\pm 60$ | mA |
| Supply Current | $\mathrm{I}_{\mathrm{sr}}$ | $\begin{aligned} & \text { No Load } \\ & \mathrm{v}_{\mathrm{O}}=\mathrm{ov} \end{aligned}$ | - | 5.1 | 6.0 | mA |
| Slew Rate | SR | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | 40 | 52 | - | V/us |
| Capacitive Load Drive Capability | $C_{L}$ | Unity-Gain Stable (Note 3) | 100 | 250 | - | pF |

## NOTES:

1. $T_{1}=85^{\circ} \mathrm{C}$ for $E / F$ Grades; $T_{1}=125^{\circ} \mathrm{C}$ for $A$ grade.
2. Guaranteed by CMR test.
3. Guaranteed but not tested.

## FEATURES

- Outstanding Gain Linearity
- Ultra High Gain $\qquad$ 5000V/mV Min
- Low Vos Over Temperature $\qquad$ $60 \mu \mathrm{~V}$ Max
- Excellent TCV $0.3 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ Max
- High PSRR $3 \mu$ V/V Max
- Low Power Consumption 60mW Max
- Fits OP-07, 725, 108A/308A, 741 Sockets
- Available in Die Form


## ORDERING INFORMATION ${ }^{\dagger}$

| PACKAGE |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
|  | CERDIP | PLASTIC | LCC | OPERATING <br> TEMPERATURE <br> RANGE |
| TO-99 | 8-PIN | 8-PIN | 20-PIN | RANG |
| OP77AJ* | OP77AZ** | - | - | MIL |
| OP77EJ | OP77EZ | - | - | IND |
| - | - | OP77EP | - | COM |
| OP77BN* | OP77BZ* | - | OP77BRC/883 | MIL |
| OP77FJ | OP77FZ | - | - | IND |
| - | - | OP77FP | - | COM |
| - | - | OP77GP | - | COM |
| - | - | OP77GS | - | COM |
| - | - | OP77HP | - | XIND |
| - | - | OP77HS | - | - |
| XIND |  |  |  |  |

* For devices processed in total compliance to MIL-SDT-883, add/883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.
tt For availability and burn-in information on SO and PLCC packages, contact your local sales office.


## GENERAL DESCRIPTION

The OP-77 significantly advances the state-of-the-art in precision op amps. The OP-77's outstanding gain of $10,000,000$ or more is maintained over the full $\pm 10 \mathrm{~V}$ output range. This exceptional gain-linearity eliminates incorrectable system nonlinearities common in previous monolithic op amps, and provides

PIN CONNECTIONS


EPOXY MINI-DIP (P-Suffix) 8-PIN HERMETIC DIP (Z-Suffix)

8-PIN SO
(S-Suffix)



TO-99 (J-Suffix)

OP-77BRC/883
LCC
(RC-Suffix)
superior performance in high closed-loop-gain applications. Low initial $V_{\text {os }}$ drift and rapid stabilization time, combined with only 50 mW power consumption, are significant improvements over previous designs. These characteristics, plus the exceptional $\mathrm{TCV}_{\text {os }}$ of $0.3 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ maximum and the low $\mathrm{V}_{\text {os }}$ of $25 \mu \mathrm{~V}$ maximum, eliminates the need for $V_{o s}$ adjustment and increases system accuracy over temperature.
PSRR of $3 \mu \mathrm{~V} / \mathrm{N}(110 \mathrm{~dB})$ and CMRR of $1.0 \mu \mathrm{~V} / \mathrm{N}$ maximum virtually eliminiate errors caused by power supply drifts and com-mon-mode signals. This combination of outstanding characteristics makes the OP-77 ideally suited for high-resolution instrumentation and other tight error budget systems. Continued

SIMPLIFIED SCHEMATIC


This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

This product is available in six standard grades and five standard packages: the TO-99 can, the 8-pin mini-DIP in ceramic, SO or epoxy, and the 20-contact LCC.
The OP-77 is a direct or upgrade replacement for the OP-07, 05, 725, or 108A op amps. 741-types can be replaced by eliminating the $V_{\text {Os }}$ adjust pot. For higher precision performance refer to OP-177.

OP-77E, OP-77F, OP-77G (P, S) $0^{\circ} \mathrm{C}$ to $70^{\circ}$

OP-77H (P, S) .............................................. $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Junction Temperature ( $\mathrm{T}_{\mathrm{f}}$ ) .............................. $-65^{\circ} \mathrm{C}$ to +150 C
Lead Temperature (Soldering, 60 sec.) ......................... $300^{\circ} \mathrm{C}$

| PACKAGE TYPE | $\Theta_{\text {ja }}$ (Note 3) | $\boldsymbol{\Theta}_{\text {jc }}$ | UNITS |
| :--- | :---: | :---: | :---: |
| TO-99 (J) | 150 | 18 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin Hermetic DIP (Z) | 148 | 16 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8 -Pin Plastic DIP (P) | 103 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 20-Contact LCC (RC, TC) | 98 | 38 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8 -Pin SO (S) | 158 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTES:

1. For supply voltages less than $\pm 22 \mathrm{~V}$, the absolute maximum input voltage is equal to the supply voltage.
2. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
3. $\Theta_{\mathrm{jA}}$ is specified for worst case mounting conditions, i.e., $\Theta_{\mathrm{jA}}$ is specified for device in socket for TO, CerDIP, P-DIP, and LCC packages; $\Theta_{j A}$ is specified for device soldered to printed circuit board for SO package.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{S}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | MIN | $\begin{gathered} \text { OP-77A } \\ \text { TYP } \end{gathered}$ | MAX | MIN | $\begin{gathered} \text { OP-77B } \\ \text { TYP } \end{gathered}$ | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input Offset Voltage | $V_{\text {OS }}$ |  | - | 10 | 25 | - | 20 | 60 | $\mu \mathrm{V}$ |
| Long-Term Input Offset Voltage Stability | $\Delta V_{\text {Os }}$ STime | (Note 1) | - | 0.2 | - | - | 0.2 | - | $\mu \mathrm{V} / \mathrm{Mo}$ |
| Input Offset Current | Ios |  | - | 0.3 | 1.5 | - | 0.3 | 2.8 | $n A$ |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ |  | -0.2 | 1.2 | 2.0 | -0.2 | 1.2 | 2.8 | $n A$ |
| Input Noise Voltage | $\theta_{\text {np-p }}$ | 0.1 Hz to 10 Hz (Note 2) | - | 0.35 | 0.6 | - | 0.35 | 0.6 | $\mu \vee p-p$ |
| Input Noise Voltage Density | $\theta_{n}$ | $\begin{aligned} & f_{0}=10 \mathrm{~Hz} \text { (Note 2) } \\ & f_{0}=100 \mathrm{~Hz} \text { (Note 2) } \\ & f_{0}=1000 \mathrm{~Hz} \text { (Note 2) } \end{aligned}$ | - | $\begin{array}{r} 10.3 \\ 10.0 \\ 9.6 \end{array}$ | $\begin{aligned} & 18.0 \\ & 13.0 \\ & 11.0 \end{aligned}$ | - | $\begin{array}{r} 10.3 \\ 10.0 \\ 9.6 \end{array}$ | $\begin{aligned} & 18.0 \\ & 13.0 \\ & 11.0 \end{aligned}$ | $\mathrm{V} / \sqrt{\mathrm{Hz}}$ |
| Input Noise Current | $i_{\text {np-p }}$ | 0.1 Hz to 10 Hz (Note 2) | - | 14 | 30 | - | 14 | 30 | pAp-p |
| Input Noise Current Density | $i_{n}$ | $\begin{aligned} & f_{0}=10 \mathrm{~Hz} \text { (Note 2) } \\ & f_{0}=100 \mathrm{~Hz} \text { (Note 2) } \\ & f_{0}=1000 \mathrm{~Hz} \text { (Note 2) } \end{aligned}$ | - | $\begin{aligned} & 0.32 \\ & 0.14 \\ & 0.12 \end{aligned}$ | $\begin{aligned} & 0.80 \\ & 0.23 \\ & 0.17 \end{aligned}$ | - | $\begin{aligned} & 0.32 \\ & 0.14 \\ & 0.12 \end{aligned}$ | $\begin{aligned} & 0.80 \\ & 0.23 \\ & 0.17 \end{aligned}$ | $\mathrm{pA} \sqrt{\mathrm{Hz}}$ |
| Input Resistance -Differential-Mode | $\mathrm{R}_{\text {IN }}$ | (Note 3) | 26 | 45 | - | 18.5 | 45 | - | M $\Omega$ |
| Input Resistance -Common-Mode | $\mathrm{R}_{\text {INCM }}$ |  | - | 200 | - | - | 200 | - | G $\Omega$ |
| Input Voltage Range | IVR |  | $\pm 13$ | $\pm 14$ | - | $\pm 13$ | $\pm 14$ | - | v |
| Common-Mode Rejection Ratio | CMRR | $V_{C M}= \pm 13 \mathrm{~V}$ | - | 0.1 | 1.0 | - | 0.1 | 1.0 | $\mu \mathrm{V} / \mathrm{V}$ |
| Power Supply Rejection Ratio | PSRR | $V_{S}= \pm 3 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | 0.7 | 3 | - | 0.7 | 3 | $\mu \mathrm{V} / \mathrm{V}$ |
| Large-Signal Voltage Gain | ${ }^{\text {vo }}$ | $R_{L} \geq 2 \mathrm{k} \Omega$, VO $= \pm 10 \mathrm{~V}$ | 5000 | 12000 | - | 2000 | 8000 | - | V/mV |
| Output Voltage Swing | $V_{0}$ | $\begin{aligned} & R_{L} \geq 10 \mathrm{k} \Omega \\ & R_{L} \geq 2 \mathrm{k} \Omega \\ & R_{L} \geq 1 \mathrm{k} \Omega \\ & \hline \end{aligned}$ | $\begin{aligned} & \pm 13.5 \\ & \pm 12.5 \\ & \pm 12.0 \end{aligned}$ | $\begin{aligned} & \pm 14.0 \\ & \pm 13.0 \\ & \pm 12.5 \end{aligned}$ | - | $\begin{aligned} & \pm 13.5 \\ & \pm 12.5 \\ & \pm 12.0 \end{aligned}$ | $\begin{aligned} & \pm 14.0 \\ & \pm 13.0 \\ & \pm 12.5 \end{aligned}$ | - | V |
| Slew Rate | SR | $\mathrm{R}_{\mathrm{L}} \geq \mathbf{2 k} \Omega$ (Note 2) | 0.1 | 0.3 | - | 0.1 | 0.3 | - | $\mathrm{V} / \mathrm{\mu s}$ |
| Closed-Loop Bandwidth | BW | $A_{\text {VCL }}=+1$ (Note 2) | 0.4 | 0.6 | - | 0.4 | 0.6 | - | MHz |
| Open-Loop Output Resistance | $\mathrm{R}_{0}$ |  | - | 60 | - | - | 60 | - | $\Omega$ |
| Power Consumption | $P_{\text {d }}$ | $\begin{aligned} & V_{S}= \pm 15 \mathrm{~V}, \text { No Load } \\ & V_{S}= \pm 3 V, \text { No Load } \end{aligned}$ | - | $\begin{array}{r} 50 \\ 3.5 \end{array}$ | 60 4.5 | - | $\begin{array}{r} 50 \\ 3.5 \end{array}$ | $\begin{aligned} & 60 \\ & 4.5 \end{aligned}$ | mW |
| Offset Adjustment Range |  | $R_{P}=20 \mathrm{k} \Omega$ | - | $\pm 3$ | - | - | $\pm 3$ | - | mV |
| NOTES: <br> 1. Long-Term Input Offset Voltage Stability refers to the averaged trend line of $\mathbf{V}_{\mathbf{0 s}}$ vs Time over extended periods after the first 30 days of operation. |  |  | Excluding the initial hour of operation, changes in $\mathrm{V}_{\mathrm{Os}}$ during the first 30 operating days are typically $2.5 \mu \mathrm{~V}$. <br> Sample tested. <br> Guaranteed by design. |  |  |  |  |  |  |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V},-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$, unless otherwise noted.

|  |  |  | OP-77A |  |  | OP-77B |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Input Offset Voltage | $\mathrm{V}_{\text {OS }}$ |  | - | 25 | 60 | - | 45 | 120 | $\mu \mathrm{V}$ |
| Average Input Offset Voltage Drift | $\mathrm{TCV}_{\text {Os }}$ | (Note 1) | - | 0.1 | 0.3 | - | 0.2 | 0.6 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current | los |  | - | 0.5 | 2.2 | - | 0.5 | 4.5 | nA |
| Average Input Offset Current Drift | $\mathrm{TCl}_{\text {os }}$ | (Note 2) | - | 1.5 | 25 | - | 1.5 | 50 | $\mathrm{pA} /{ }^{\circ} \mathrm{C}$ |
| Input Bias Current | $I_{B}$ |  | -0.2 | 2.4 | 4 | -0.2 | 2.4 | 6 | $\mathrm{n} . \mathrm{A}$ |
| Average Input Bias Current Drift | $\mathrm{TCl}_{\mathrm{B}}$ | (Note 2) | - | 8 | 25 | - | 15 | 35 | $\mathrm{pA} /{ }^{\circ} \mathrm{C}$ |
| Input Voltage Range | IVR |  | $\pm 13$ | $\pm 13.5$ | - | $\pm 13$ | $\pm 13.5$ | - | V |
| Common-Mode Rejection Ratio | CMRR | $\mathrm{V}_{\mathrm{CM}}= \pm 13 \mathrm{~V}$ | - | 0.1 | 1.0 | - | 0.1 | 3 | $\mu \mathrm{V} / \mathrm{V}$ |
| Power Supply Rejection Ratio | PSRR | $\mathrm{V}_{S}= \pm 3 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | 1 | 3 | - | 1 | 5 | $\mu \mathrm{V} / \mathrm{V}$ |
| Large-Signal Voltage Gain | Avo | $\mathrm{R}_{\mathrm{L}} \geq 2 \mathrm{k} \Omega, \mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V}$ | 2000 | 6000 | - | 1000 | 4000 | - | $\mathrm{V} / \mathrm{mV}$ |
| Output Voltage Swing | $V_{0}$ | $R_{L} \geq 2 \mathrm{k} \Omega$ | $\pm 12$ | $\pm 13.0$ | - | $\pm 12$ | $\pm 13.0$ | - | V |
| Power Consumption | $\mathrm{P}_{\mathrm{d}}$ | $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}$, No Load | - | 60 | 75 | - | 60 | 75 | mW |

## NOTES:

1. OP-77A: TCV $_{\text {OS }}$ is $100 \%$ tested.
2. Guaranteed by end-point limits.

TYPICAL OFFSET VOLTAGE TEST CIRCUIT


## OPTIONAL OFFSET NULLING CIRCUIT



TYPICAL LOW-FREQUENCY NOISE TEST CIRCUIT


BURN-IN CIRCUIT


ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-77E |  |  | OP-77F |  |  | OP-77G/H |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Input Offset Voltage | $\mathrm{V}_{\text {OS }}$ |  | - | 10 | 25 | - | 20 | 60 | - | 50 | 100 | ${ }^{\boldsymbol{V}}$ |
| Long-Term $\mathrm{V}_{\mathrm{OS}}$ Stability | $\mathrm{V}_{\text {OS }} /$ Time | (Note 1) | - | 0.3 | - | - | 0.4 | - | - | 0.4 | - | $\mu \mathrm{V} / \mathrm{Mo}$ |
| Input Offset Current | $\mathrm{I}_{\mathrm{os}}$ |  | - | 0.3 | 1.5 | - | 0.3 | 2.8 | - | 0.3 | 2.8 | nA |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ |  | -0.2 | 1.2 | 2.0 | -0.2 | 1.2 | 2.8 | -0.2 | 1.2 | 2.8 | nA |
| Input Noise Voltage | $e_{n p-p}$ | 0.1 Hz to 10 Hz <br> (Note 2) | - | 0.35 | 0.6 | - | 0.38 | 0.65 | - | 0.38 | 0.65 | $\mu \mathrm{V}_{\mathrm{p}-\mathrm{p}}$ |
| Input Noise Voltage Density | $e_{n}$ | $\mathrm{f}_{\mathrm{O}}=10 \mathrm{~Hz}$ | - | 10.3 | 18.0 | - | 10.5 | 20.0 | - | 10.5 | 20.0 |  |
|  |  | $\mathrm{f}_{\mathrm{O}}=100 \mathrm{~Hz}$ (Note 2) | - | 10.0 | 13.0 | - | 10.2 | 13.5 | - | 10.2 | 13.5 | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
|  |  | $\mathrm{f}_{\mathrm{O}}=1000 \mathrm{~Hz}$ | - | 9.6 | 11.0 | - | 9.8 | 11.5 | - | 9.8 | 11.5 |  |
| Input Noise Current | $i_{\text {np-p }}$ | 0.1 Hz to 10 Hz (Note 2) | - | 14 | 30 | - | 15 | 35 | - | 15 | 35 | $p A_{p-p}$ |
| Input Noise Current Density | $i_{n}$ | $\mathrm{f}_{\mathrm{O}}=10 \mathrm{~Hz}$ | - | 0.32 | 0.80 | - | 0.35 | 0.90 | - | 0.35 | 0.90 | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
|  |  | $\mathrm{f}_{\mathrm{O}}=100 \mathrm{~Hz}$ (Note 2) | - | 0.14 | 0.23 | - | 0.15 | 0.27 | - | 0.15 | 0.27 |  |
|  |  | $\mathrm{f}_{\mathrm{O}}=1000 \mathrm{~Hz}$ | - | 0.12 | 0.17 | - | 0.13 | 0.18 | - | 0.13 | 0.18 |  |
| Input Resistance -Differential-Mode | $\mathrm{R}_{\text {IN }}$ | (Note 3) | 26 | 45 | - | 18.5 | 45 | - | 18.5 | 45 | - | $\mathrm{M} \Omega$ |
| Input Resistance -Common-Mode | $\mathrm{R}_{\text {INCM }}$ |  | - | 200 | - | - | 200 | - | - | 200 | - | G $\Omega$ |
| Input Voltage Range | IVR |  | $\pm 13$ | $\pm 14$ | - | $\pm 13$ | $\pm 14$ | - | $\pm 13$ | $\pm 14$ | - | V |
| Common-Mode Rejection Ratio | CMRR | $\mathrm{V}_{\mathrm{CM}}= \pm 13 \mathrm{~V}$ | - | 0.1 | 1.0 | - | 0.1 | 1.6 | - | 0.1 | 1.6 | $\mu \mathrm{V} / \mathrm{V}$ |
| Power Supply Rejection Ratio | PSRR | $V_{S}= \pm 3 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | 0.7 | 3.0 | - | 0.7 | 3.0 | - | 0.7 | 3.0 | $\mu \mathrm{V} / \mathrm{V}$ |
| Large-Signal Voltage Gain | $A_{\text {vo }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}} \geq 2 \mathrm{k} \Omega \\ & \mathrm{~V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \end{aligned}$ | 5000 | 12000 | - | 2000 | 6000 | - | 2000 | 6000 | - | V/mV |
| Output Voltage Swing | $\mathrm{V}_{0}$ | $\mathrm{R}_{\mathrm{L}} \geq 10 \mathrm{k} \Omega$ | $\pm 13.5$ | $\pm 14.0$ | - | $\pm 13.5$ | $\pm 14.0$ | - | $\pm 13.5$ | $\pm 14.0$ | - | V |
|  |  | $\mathrm{R}_{\mathrm{L}} \geq 2 \mathrm{k} \Omega$ | $\pm 12.5$ | $\pm 13.0$ | - | $\pm 12.5$ | $\pm 13.0$ | - | $\pm 12.5$ | $\pm 13.0$ | - |  |
|  |  | $R_{L} \geq 1 \mathrm{k} \Omega$ | $\pm 12.0$ | $\pm 12.5$ | - | $\pm 12.0$ | $\pm 12.5$ | - | $\pm 12.0$ | $\pm 12.5$ | - |  |
| Slew Rate | SR | $\mathrm{R}_{\mathrm{L}} \geq 2 \mathrm{k} \Omega$ (Note 2) | 0.1 | 0.3 | - | 0.1 | 0.3 | - | 0.1 | 0.3 | - | $\mathrm{V} / \mu \mathrm{s}$ |
| Closed-Loop <br> Bandwidth | BW | $\mathrm{A}_{\mathrm{VCL}}=+1$ <br> (Note 2) | 0.4 | 0.6 | - | 0.4 | 0.6 | - | 0.4 | 0.6 | - | MHz |
| Open-Loop Output Resistance | $\mathrm{R}_{0}$ |  | - | 60 | - | - | 60 | - | - | 60 | - | $\Omega$ |
| Power Consumption | $\mathrm{P}_{\mathrm{d}}$ | $V_{S}= \pm 15 \mathrm{~V}$, No Load | - | 50 | 60 | - | 50 | 60 | - | 50 | 60 | mW |
|  |  | $V_{S}= \pm 3 \mathrm{~V}$, No Load . | - | 3.5 | 4.5 | - | 3.5 | 4.5 | - | 3.5 | 4.5 |  |
| Offset Adjustment Range |  | $\mathrm{R}_{\mathrm{P}}=20 \mathrm{k} \Omega$ | - | $\pm 3$ | - | - | $\pm 3$ | - | - | $\pm 3$ | - | mV |

## NOTES:

1. Long-Term Input Offset Voltage Stability refers to the averaged trend line of $\mathrm{V}_{\mathrm{OS}} \mathrm{vs}$. Time over extended periods after the first 30 days of operation. Excluding the initial hour of operation, changes in $\mathrm{V}_{\mathrm{OS}}$ during the first 30 operating days are typically $2.5 \mu \mathrm{~V}$.
2. Sample tested.
3. Guaranteed by design.

ELECTRICAL CHARACTERISTICS at $V_{S}= \pm 15 \mathrm{~V},-25^{\circ} \mathrm{C} \leq T_{A} \leq+85^{\circ} \mathrm{C}$ for OP-77E/FJ and OP-77E/FZ, $0^{\circ} \mathrm{C} \leq T_{A} \leq+70^{\circ} \mathrm{C}$ for OP-77E/F/GP/GS, $-40^{\circ} \mathrm{C} \leq \mathrm{TA} \leq+85^{\circ} \mathrm{C}$ for OP-77HP/HS, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-77E |  |  | OP-77F |  |  | OP-77G/H |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN |  | MAX |  |
| Input Offset Voltage | VOS | J, Z Packages P Package | - | $\begin{aligned} & 10 \\ & 10 \end{aligned}$ | $\begin{array}{r} 45 \\ 55 \end{array}$ | - | $\begin{aligned} & 20 \\ & 20 \end{aligned}$ | $\begin{aligned} & 100 \\ & 100 \end{aligned}$ | - | 80 | 150 | $\mu \mathrm{V}$ |
| Average Input Offset Voltage Drift | $\mathrm{TVC}_{\text {OS }}$ | $\begin{array}{ll} \text { J, Z Packages } \\ \text { P Package } & \text { (Note 1) } \end{array}$ | - | $\begin{aligned} & 0.1 \\ & 0.3 \end{aligned}$ | $\begin{aligned} & 0.3 \\ & 0.6 \end{aligned}$ | - | $\begin{aligned} & 0.2 \\ & 0.4 \end{aligned}$ | $\begin{aligned} & 0.6 \\ & 1.0 \end{aligned}$ | - | 0.7 | 1.2 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current | los |  | - | 0.5 | 2.2 | - | 0.5 | 4.5 | - | 0.5 | 4.5 | nA |
| Average Input Offset Current Drift | $\mathrm{TCl}_{\mathrm{os}}$ | (Note 2) | - | 1.5 | 40 | - | 1.5 | 85 | - | 1.5 | 85 | pA ${ }^{\circ} \mathrm{C}$ |
| Input Bias Current | $I_{B}$ | E, F, G Grades H Grade | $-0.2$ | 2.4 | 4.0 | -0.2 - | 2.4 | 6.0 | -0.2 - | $\begin{aligned} & 2.4 \\ & 2.4 \end{aligned}$ | $\begin{array}{r} 6.0 \\ \pm 6.0 \end{array}$ | nA |
| Average Input Bias Current Drift | $\mathrm{TCl}_{\mathrm{B}}$ | (Note 2) | - | 8 | 40 | - | 15 | 60 | - | 15 | 60 | pA ${ }^{\circ} \mathrm{C}$ |
| Input Voltage Range | IVR |  | $\pm 13.0$ | $\pm 13.5$ | - | $\pm 13.0$ | $\pm 13.5$ | - | $\pm 13.0$ | $\pm 13.5$ | - | V |
| Common-Mode Rejection Ratio | CMRR | $V_{C M}= \pm 13 \mathrm{~V}$ | - | 0.1 | 1.0 | - | 0.1 | 3.0 | - | 0.1 | 3.0 | $\mu \mathrm{V} / \mathrm{N}$ |
| Power Supply Rejection Ratio | PSRR | $\mathrm{V}_{\mathrm{S}}= \pm 3 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | 1.0 | 3.0 | - | 1.0 | 5.0 | - | 1.0 | 5.0 | $\mu \mathrm{V} N$ |
| Large-Signal Voltage Gain | Avo | $\begin{aligned} & R_{L} \geq 2 \mathrm{k} \Omega \\ & \mathrm{~V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \end{aligned}$ | 2000 | 6000 | - | 1000 | 4000 | - | 1000 | 4000 | - | V/mV |
| Output Voltage Swing | $v_{0}$ | $R_{L}=2 \mathrm{k} \Omega$ | $\pm 12$ | $\pm 13.0$ | - | $\pm 12$ | $\pm 13.0$ | - | $\pm 12$ | $\pm 13.0$ | - | V |
| Power Consumption | $P_{d}$ | $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}$, No Load | - | 60 | 75 | - | 60 | 75 | - - | 60 | 75 | mW |

NOTES:

1. OP-77E: TCV $_{\text {Os }}$ is $100 \%$ tested on $J$ and $Z$ packages.
2. Guaranteed by end-point limits.

## OPEN-LOOP GAIN LINEARITY



Actual open-loop voltage gain can vary greatly at various output voltages. All automated testers use end-point testing and therefore only show the average gain. This causes errors in high closed-loop gain circuits. Since this is so difficult for manufacturers to test, you should make your own evaluation. This simple test circuit makes it easy. An ideal op amp would show a horizontal scope trace.


This is the output gain linearity trace for the new OP-77. The output trace is virtually horizontal at all points, assuring extremely high gain accuracy. The average open-loop gain is truly impressive - approximately $10,000,000$.

## FEATURES

- Single/Dual Supply Operation $\qquad$ +1.6 V to +36 V +0.8 V to $\pm 18 \mathrm{~V}$
- True Single-Supply Operation; Input and Output Voltage Ranges Include Ground
- Low Supply Current 20 $\mu$ A Max
- High Output Drive $\qquad$ 5mA Min
- Low Input Offset Voltage $150 \mu \mathrm{~V}$ Max
- High Open-Loop Gain $700 \mathrm{~V} / \mathrm{mV}$ Min
- Outstanding PSRR 5.6 $\mu$ V/V Max
- Standard 741 Pinout with Nulling to V-
- Available in Die Form


## GENERAL DESCRIPTION

The OP-90 is a high performance micropower op amp that operates from a single supply of +1.6 V to +36 V or from dual supplies of $\pm 0.8$ to $\pm 18 \mathrm{~V}$. Input voltage range includes the negative rail allowing the OP-90 to accommodate input signals down to ground in single supply operation. The OP-90's output swing also includes ground when operating from a single supply, enabling "zero-in, zero-out" operation.
The OP-90 draws less than $20 \mu \mathrm{~A}$ of quiescent supply current, while able to deliver over 5 mA of output current to a load. Input offset voltage is below $150 \mu \mathrm{~V}$ eliminating the need for external nulling. Gain exceeds 700,000 and common-mode rejection is better than 100 dB . The power supply-rejection ratio of under $5.6 \mu \mathrm{~V} / \mathrm{V}$ minimizes offset voltage changes experienced in battery powered systems.
The low offset voltage and high gain offered by the OP-90 bring precision performance to micropower applications. The minimal voltage and current requirements of the OP-90

PIN CONNECTIONS

suit it for battery and solar powered applications, such as portable instruments, remote sensors, and satellites.

ORDERING INFORMATION ${ }^{\dagger}$

SIMPLIFIED SCHEMATIC


[^180]

| Junction Temperature ( $T$ ) ........................... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ <br> Lead Temperature (Soldering, 60 sec ) $\qquad$ $+300^{\circ} \mathrm{C}$ |  |  |  |
| :---: | :---: | :---: | :---: |
| PACKAGE TYPE | $\theta_{14}($ Note 2) | $\theta_{16}$ | UNITS |
| 8-Pin Hermetic DIP (Z) | 148 | 16 | ${ }^{\circ} \mathrm{CN}$ |
| 8 -Pin Plastic DIP (P) | 103 | 43 | ${ }^{\circ} \mathrm{CN}$ |
| 20-Contact LCC (RC) | 98 | 38 | ${ }^{\circ} \mathrm{CN}$ |
| 8 -Pin SO (S) | 158 | 43 | ${ }^{\circ} \mathrm{CN}$ |
| NOTES: |  |  |  |
| 1. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted. |  |  |  |
| 2. $\boldsymbol{\theta}_{j A}$ is specified for worst case mounting conditions, i.e., $\boldsymbol{\theta}_{\mid \mathrm{A}}$ is specified for device in socket for CerDIP, P-DIP, and LCC packages; $\Theta_{j A}$ is specified for device soldered to printed circuit board for SO package. |  |  |  |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 1.5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-90A/E |  |  | OP-90F |  |  | OP-90G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Input Offset Voltage | $\mathrm{V}_{\text {OS }}$ |  | - | 50 | 150 | - | 75 | 250 | - | 125 | 450 | $\mu \mathrm{V}$ |
| Input Offset Current | Ios | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 0.4 | 3 | - | 0.4 | 5 | - | 0.4 | 5 | nA |
| Input Bias Current | $\mathrm{I}_{B}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 4.0 | 15 | - | 4.0 | 20 | - | 4.0 | 25 | nA |
| Large Signal Voltage Gain | $A_{\text {vo }}$ | $\mathrm{V}_{S}= \pm 15 \mathrm{~V}, \mathrm{~V}_{\mathrm{O}}= \pm 10 \mathrm{~V}$ |  |  |  |  |  |  |  |  |  | $\mathrm{V} / \mathrm{mV}$ |
|  |  | , $\mathrm{R}_{\mathrm{L}}=100 \mathrm{k} \Omega$ | 700 | 1200 | - | 500 | 1000 | - | 400 | 800 | - |  |
|  |  | $R_{L}=10 \mathrm{k} \Omega$ | 350 | 600 | - | 250 | 500 | - | 200 | 400 | - |  |
|  |  | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | 125 | 250 | - | 100 | 200 | - | 100 | 200 | - |  |
|  |  | $\mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V}$, |  |  |  |  |  | - |  |  |  |  |
|  |  | $1 \mathrm{~V}<\mathrm{V}_{\mathrm{O}}<4 \mathrm{~V}$ |  |  |  |  |  |  |  |  |  |  |
|  |  | $R_{L}=100 \mathrm{k} \Omega$ | 200 | 400 | - | 125 | 300 | - | 100 | 250 | - |  |
|  |  | $R_{L}=10 \mathrm{k} \Omega$ | 100 | 180 | - | 75 | 140 | - | 70 | 140 | - |  |
| Input Voltage Range | IVR | $\mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V}$ | 0/4 | - | - | 0/4 | - | - | 0/4 | - | - | V |
|  |  | $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V} \quad$ (Note 2) | -15/13.5 | - | - | -15/13.5 | - | - | -15/13.5 | - | - |  |
| Output Voltage Swing | $\mathrm{V}_{\mathrm{O}}$ | $\begin{gathered} V_{S}= \pm 15 \mathrm{~V} \\ R_{\mathrm{L}}=10 \mathrm{k} \Omega \\ R_{\mathrm{L}}=2 \mathrm{k} \Omega \\ \hline \end{gathered}$ |  |  |  |  |  |  |  |  |  | V |
|  |  |  | $\pm 14$ | $\pm 14.2$ | - | $\pm 14$ | $\pm 14.2$ | - | $\pm 14$ | $\pm 14.2$ | - |  |
|  |  |  | $\pm 11$ | $\pm 12$ | - | $\pm 11$ | $\pm 12$ | - | $\pm 11$ | $\pm 12$ | - |  |
|  | $\mathrm{V}_{\mathrm{OH}}$ | $\begin{gathered} \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V} \\ \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \end{gathered}$ | 4.0 | 4.2 | - | 4.0 | 4.2 | - | 4.0 | 4.2 | - | V |
|  | $\mathrm{V}_{\mathrm{OL}}$ | $\begin{gathered} \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V} \\ \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \end{gathered}$ | - | 100 | 500 | - | 100 | 500 | - | 100 | 500 | $\mu \mathrm{V}$ |
| Common Mode Rejection | CMR | $\begin{aligned} & \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V}, \\ & 0 \mathrm{~V}<\mathrm{V}_{\mathrm{CM}}<4 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V} \\ & -15 \mathrm{~V}<\mathrm{V}_{\mathrm{CM}}<13.5 \mathrm{~V} \end{aligned}$ | 90 | 110 | - | 80 | 100 | - | 80 | 100 | - | dB |
|  |  |  | 100 | 130 | - | 90 | 120 | - | 90 | 120 | - |  |
| Power Supply Rejection Ratio | PSRR |  | - | 1.0 | 5.6 | - | 1.0 | 5.6 | - | 3.2 | 10 | $\mu \mathrm{V} / \mathrm{V}$ |
| Slew Rate | SR | $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}$ | 5 | 12 | - | 5 | 12 | - | 5 | 12 | - | $\mathrm{V} / \mathrm{ms}$ |
| Supply Current | $I_{\text {SY }}$ | $\mathrm{V}_{\mathrm{S}}= \pm 1.5 \mathrm{~V}$ | - | 9 | 15 | - | 9 | 15 | - | 9 | 15 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}$ | - | 14 | 20 | - | 14 | 20 | - | 14 | 20 |  |
| Capacitive Load Stability |  | $A_{\mathbf{V}}=+1$ <br> No Oscillations <br> (Note 1) | 250 | 650 | - | 250 | 650 | - | 250 | 650 | - | pF |
| Input Noise Voltage | $e_{n p-p}$ | $\begin{aligned} & \mathrm{f}_{\mathrm{O}}=0.1 \mathrm{~Hz} \text { to } 10 \mathrm{~Hz} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V} \end{aligned}$ | - | 3 | - | - | 3 | - | - | 3 | - | $\mu \mathrm{V}_{\mathrm{p}-\mathrm{p}}$ |
| Input Resistance Differential Mode | $\mathrm{R}_{\text {IN }}$ | $\dot{V}_{S}= \pm 15 \mathrm{~V}$ | - | 30 | - | - | 30 | - | - | 30 | - | M $\Omega$ |
| Input Resistance Common Mode | $\mathrm{R}_{\text {INCM }}$ | $\mathrm{V}_{S}= \pm 15 \mathrm{~V}$ | - | 20 | - | - | 20 | - | - | 20 | - | G $\Omega$ |

## NOTES:

1. Guaranteed but not $100 \%$ tested.
2. Guaranteed by CMR test.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 1.5 \mathrm{~V}$ to $\pm 15 \mathrm{~V},-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq 125^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | MIN | $\begin{gathered} \text { OP-90A } \\ \text { TYP } \end{gathered}$ | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input Offset Voltage | $\mathrm{V}_{\text {OS }}$ |  | - | 80 | 400 | $\mu \mathrm{V}$ |
| Average Input Offset Voltage Drift | $\mathrm{TCV}_{\text {Os }}$ |  | - | 0.3 | 2.5 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current | Ios | $V_{C M}=0 \mathrm{~V}$ | - | 1.5 | 5 | $n \mathrm{~A}$ |
| Input Bias Current | $I_{B}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 4.0 | 20 | nA |
| Large Signal | $A_{\text {vo }}$ | $\begin{aligned} & V_{S}= \pm 15 \mathrm{~V}, V_{O}= \pm 10 \mathrm{~V} \\ & R_{L}=100 \mathrm{k} \Omega \\ & R_{L}=10 \mathrm{k} \Omega \\ & R_{L}=2 \mathrm{k} \Omega \\ & \hline \end{aligned}$ | $\begin{array}{r} 225 \\ 125 \\ 50 \end{array}$ | $\begin{array}{r} 400 \\ 240 \\ 110 \end{array}$ | - | V/mV |
|  |  | $\begin{gathered} \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V}, \\ 1 \mathrm{~V}<\mathrm{V}_{\mathrm{O}}<4 \mathrm{~V} \\ R_{\mathrm{L}}=100 \mathrm{k} \Omega \\ \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \\ \hline \end{gathered}$ | $\begin{array}{r} 100 \\ 50 \\ \hline \end{array}$ | $\begin{array}{r} 200 \\ 110 \\ \hline \end{array}$ | - |  |
| Input Voltage Range | IVR | $\begin{aligned} & \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V} \\ & \left.\mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V} \quad \text { Note } 1\right) \end{aligned}$ | $\begin{array}{r} 0 / 3.5 \\ -15 / 13.5 \end{array}$ | - | - | V |
|  | $\mathrm{V}_{0}$ | $\begin{gathered} V_{S}= \pm 15 \mathrm{~V} \\ R_{L}=10 \mathrm{k} \Omega \\ R_{L}=2 \mathrm{k} \Omega \\ \hline \end{gathered}$ | $\begin{aligned} & \pm 13.5 \\ & \pm 10.5 \\ & \hline \end{aligned}$ | $\begin{aligned} & \pm 13.7 \\ & \pm 11.5 \\ & \hline \end{aligned}$ | - | V |
| Output Voltage Swing | $\mathrm{V}_{\mathrm{OH}}$ | $\begin{gathered} \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V} \\ \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \end{gathered}$ | 3.9 | 4.1 | - | V |
|  | $\mathrm{V}_{\mathrm{OL}}$ | $\begin{gathered} \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V} \\ \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \end{gathered}$ | - | 100 | 500 | $\mu \mathrm{V}$ |
| Common Mode Rejection | CMR | $\begin{aligned} & V+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V}, 0 \mathrm{~V}<\mathrm{V}_{\mathrm{CM}}<3.5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V},-15 \mathrm{~V}<\mathrm{V}_{\mathrm{CM}}<13.5 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 85 \\ & 95 \end{aligned}$ | $\begin{aligned} & 105 \\ & 115 \end{aligned}$ | - | dB |
| Power Supply Rejection Ratio | PSRR |  | - | 3.2 | 10 | $\mu \mathrm{V} / \mathrm{V}$ |
| Supply Current | $I_{\text {SY }}$ | $\begin{aligned} & V_{S}= \pm 1.5 \mathrm{~V} \\ & V_{S}= \pm 15 \mathrm{~V} \end{aligned}$ | - | $\begin{aligned} & 15 \\ & 19 \end{aligned}$ | $\begin{aligned} & 25 \\ & 30 \end{aligned}$ | $\mu \mathrm{A}$ |

## NOTE:

1. Guaranteed by CMR test.

ELECTRICAL CHARACTERISTICS at $V_{S}= \pm 1.5 \mathrm{~V}$ to $\pm 15 \mathrm{~V},-25^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ for OP-90E/F, $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ for OP-90G, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-90E |  |  | OP-90F |  |  | OP-90G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Input Offset Voltage | $\mathrm{V}_{\mathrm{OS}}$ |  | - | 70 | 270 | - | 110 | 550 | - | 180 | 675 | $\mu \mathrm{V}$ |
| Average Input Offset Voltage Drift | $\mathrm{TCV}_{\text {Os }}$ |  | - | 0.3 | 2 | - | 0.6 | 5 | - | 1.2 | 5 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current | los | $\mathrm{V}_{C M}=0 \mathrm{~V}$ | - | 0.8 | 3 | - | 1.0 | 5 | - | 1.3 | 7 | $n \mathrm{~A}$ |
| Input Bias Current | $I_{B}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 4.0 | 15 | - | 4.0 | 20 | - | 4.0 | 25 | nA |
| Large Signal Voltage Gain | Avo | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \\ & R_{\mathrm{L}}=100 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \\ & R_{\mathrm{L}}=2 \mathrm{k} \Omega \end{aligned}$ | $\begin{aligned} & 500 \\ & 250 \\ & 100 \\ & \hline \end{aligned}$ | $\begin{aligned} & 800 \\ & 400 \\ & 200 \end{aligned}$ | - | 350 175 75 | 700 350 150 | - | 300 150 75 | $\begin{array}{r} 600 \\ 250 \\ 125 \\ \hline \end{array}$ | - | $\mathrm{V} / \mathrm{mV}$ |
|  |  | $\begin{gathered} \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V}, \\ 1 \mathrm{~V}<\mathrm{V}_{\mathrm{O}}<4 \mathrm{~V} \\ \mathrm{R}_{\mathrm{L}}=100 \mathrm{k} \Omega \\ \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \\ \hline \end{gathered}$ | 150 75 | 280 140 | - | 100 50 | 220 110 | - | 80 40 | 160 90 | - |  |
| Input Voltage Range | IVR | $\begin{aligned} & \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V} \quad \text { (Note 1) } \end{aligned}$ | $\begin{array}{r} 0 / 3.5 \\ -15 / 13.5 \end{array}$ | - | - | $\begin{array}{r} 0 / 3.5 \\ -15 / 13.5 \\ \hline \end{array}$ | - | - | $\begin{array}{r} 0 / 3.5 \\ -15 / 13.5 \\ \hline \end{array}$ | - | - | V |
| Output Voltage Swing | $\mathrm{V}_{0}$ | $\begin{gathered} V_{S}= \pm 15 \mathrm{~V} \\ R_{\mathrm{L}}=10 \mathrm{k} \Omega \\ \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \end{gathered}$ | $\begin{aligned} & \pm 13.5 \\ & \pm 10.5 \\ & \hline \end{aligned}$ | $\begin{array}{r}  \pm 14 \\ \pm 11.8 \\ \hline \end{array}$ | - | $\begin{aligned} & \pm 13.5 \\ & \pm 10.5 \\ & \hline \end{aligned}$ | $\begin{array}{r}  \pm 14 \\ \pm 11.8 \end{array}$ | - | $\begin{aligned} & \pm 13.5 \\ & \pm 10.5 \\ & \hline \end{aligned}$ | $\begin{array}{r}  \pm 14 \\ \pm 11.8 \\ \hline \end{array}$ | - | V |
|  | $\mathrm{V}_{\mathrm{OH}}$ | $\begin{gathered} \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V} \\ \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \end{gathered}$ | 3.9 | 4.1 | - | 3.9 | 4.1 | - | 3.9 | 4.1 | - | V |
|  | $V_{\text {OL }}$ | $\begin{gathered} \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V} \\ \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \end{gathered}$ | - | 100 | 500 | - | 100 | 500 | - | 100 | 500 | $\mu \mathrm{V}$ |
| Common Mode Rejection | CMR | $\begin{aligned} & \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V}, \\ & 0 \mathrm{~V}<\mathrm{V}_{\mathrm{CM}}<3.5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \\ & -15 \mathrm{~V}<\mathrm{V}_{\mathrm{CM}}<13.5 \mathrm{~V} \end{aligned}$ | 90 100 | 110 $120$ | - - | 80 90 | 100 110 | - - | 80 90 | 100 110 | - | dB |
| Power Supply Rejection Ratio | PSRR |  | - | 1.0 | 5.6 | - | 3.2 | 10 | - | 5.6 | 17.8 | $\mu \mathrm{V} / \mathrm{V}$ |
| Supply Current | $I_{\text {SY }}$ | $\begin{aligned} & V_{S}= \pm 1.5 \mathrm{~V} \\ & V_{S}= \pm 15 \mathrm{~V} \\ & \hline \end{aligned}$ | - | 13 17 | 25 30 | - | 13 17 | 25 30 | - | 12 16 | 25 30 | $\mu \mathrm{A}$ |

## NOTE:

1. Guaranteed by CMR test.

ANALOG
DEVICES

# Low Power, High Precision Operational Amplifier 

## OP97

## FEATURES

- Low Supply Current $\qquad$ $600 \mu \mathrm{~A}$ Max
- OP-07 Type Performance Offset Voltage $20 \mu \mathrm{~V}$ Max Offset Voltage Drift $\qquad$ $0.6 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ Max
- Very Low Bias Current
$25^{\circ} \mathrm{C}$
100pA Max
$-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
250pA Max
- High Common-Mode Rejection ....................... 114dB Min
- Extended Industrial Temp. Range $\qquad$ $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
- Avallable in Die Form


## ORDERING INFORMATION ${ }^{\dagger}$

|  | PACKAGE |  | OPERATING <br> TEMPERATURE |
| :---: | :---: | :---: | :---: |
| TO-99 | CERDIP | PLASTIC | RANGE |
| OP97AJ* | OP97AZ* | - | MIL |
| OP97EJ | OP97EZ | OP97EP | XIND |
| OP97FJ | OP97FZ | OP97FP | XIND |
| - | - | OP97FS ${ }^{\dagger \dagger}$ | XIND |

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## GENERAL DESCRIPTION

The OP-97 is a low-power alternative to the industry-standard OP-07 precision amplifier. The OP-97 maintains the standards of performance set by the OP-07 while utilizing only $600 \mu \mathrm{~A}$ supply current, less than $1 / 6$ that of an OP-07. Offset voltage is an ultra-low $25 \mu \mathrm{~V}$, and drift over temperature is below $0.6 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$. External offset trimming is not required in the majority of circuits.

PIN CONNECTIONS


EPOXY MINI-DIP (P-Suffix)
8-PIN CERDIP (Z-Suffix)
EPOXY SO $\dagger \dagger$ (S-Suffix)


## OP97

Improvements have been made over OP-07 specifications in several areas. Notable is bias current, which remains below 250pA over the full military temperature range. The OP-97 is ideal for use in precision long-term integrators or sample-andhold circuits that must operate at elevated temperatures.
Common-mode rejection and power-supply rejection are also improved with the OP-97, at 114 dB minimum over wider ranges of common-mode or supply voltage. Outstanding PSR, a supply range specified from $\pm 2.25 \mathrm{~V}$ to $\pm 20 \mathrm{~V}$ and the OP-97's minimal power requirements combine to make the OP-97 a preferred device for portable and battery-powered instruments.
The OP-97 conforms to the OP-07 pinout, with the null potentiometer connected between pins 1 and 8 with the wiper to $\mathrm{V}+$. The OP-97 will upgrade circuit designs using 725, OP05, OP07, OP12, and 1012 type amplifiers. It may replace 741-type amplifiers in circuits without nulling or where the nulling circuitry has been removed.
ABSOLUTE MAXIMUM RATINGS (Note 1)
Supply Voltage ..... $\pm 20 \mathrm{~V}$
Input Voltage (Note 3) ..... $\pm 20 \mathrm{~V}$
Differential Input Voltage (Note 4) ..... $\pm 1 \mathrm{~V}$
Differential Input Current (Note 4) ..... $\pm 10 \mathrm{~mA}$

Output Short-Circuit Duration ................................... Indefinite Operating Temperature Range

| OP-97A (J, Z) |  |  | $25^{\circ} \mathrm{C}$ |
| :---: | :---: | :---: | :---: |
| OP-97E, F (J, P, |  | - | $85^{\circ} \mathrm{C}$ |
| Storage Temperat | ......... | -65 | $150^{\circ} \mathrm{C}$ |
| Junction Temperat |  | -6 | $150^{\circ} \mathrm{C}$ |
| Lead Temperature | g, 60 sec ) |  | $300^{\circ} \mathrm{C}$ |
| PACKAGE TYPE | $\theta_{\text {ja }}$ (Note 2) | $\theta_{\text {jc }}$ | UNITS |
| T0-99 (J) | 150 | 18 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8 8-Pin Hermetic DIP (Z) | 148 | 16 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8 -Pin Plastic DIP (P) | 103 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8 -Pin SO (S) | 158 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTES:

1. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
2. $\Theta_{\mathrm{jA}}$ is specified for worst case mounting conditions, i.e., $\Theta_{\mathrm{iA}}$ is specified for device in socket for TO, CerDIP, and P-DIP packages; $\Theta_{i A}$ is specified for device soldered to printed circuit board for SO package.
3. For supply voltages less than $\pm 20 \mathrm{~V}$, the absolute maximum input voltage is equal to the supply voltage.
4. The OP-97's inputs are protected by back-to-back diodes. Current-limiting resistors are not used in order to achieve low noise. Differential input voltages greater than 1 V will cause excessive current to flow through the input protection diodes unless limiting resistance is used.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-97A/E |  |  | OP-97F |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Input Offset Voltage | $\mathrm{V}_{\text {OS }}$ |  | - | 10 | 25 | - | 30 | 75 | $\mu \mathrm{V}$ |
| Long-Term Offset Voltage Stability | $\Delta \mathrm{V}_{\text {OS }} /$ Time |  | - | 0.3 | - | - | 0.3 | - | $\mu \mathrm{V} / \mathrm{Month}$ |
| Input Offset Current | los |  | - | 30 | 100 | - | 30 | 150 | pA |
| Input Bias Current | $I_{B}$ |  | - | $\pm 30$ | $\pm 100$ | - | $\pm 30$ | $\pm 150$ | pA |
| Input Noise Voltage | $e_{n p-p}$ | 0.1 Hz to 10 Hz | - | 0.5 | - | - | 0.5 | - | $\mu \mathrm{V}_{\mathrm{p}-\mathrm{p}}$ |
| Input Noise Voltage Density | $e_{n}$ | $\begin{aligned} & f_{\mathrm{O}}=10 \mathrm{~Hz}(\text { Note } 2) \\ & \mathrm{f}_{\mathrm{O}}=1000 \mathrm{~Hz}(\text { Note } 3) \end{aligned}$ | - | $\begin{aligned} & 17 \\ & 14 \end{aligned}$ | $\begin{aligned} & 30 \\ & 22 \end{aligned}$ | $\rightarrow$ | $\begin{aligned} & 17 \\ & 14 \end{aligned}$ | $\begin{aligned} & 30 \\ & 22 \end{aligned}$ | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ <br> $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| Input Noise Current Density | ${ }^{\mathbf{N}}$ N | $\mathrm{f}_{\mathrm{O}}=10 \mathrm{~Hz}$ | - | 20 | - | - | 20 | - | $\mathrm{fA} / \sqrt{\mathrm{Hz}}$ |
| Large-Signal Voltage Gain | $A_{\text {vo }}$ | $\mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V} ; \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | 300 | 2000 | - | 200 | 2000 | - | $\mathrm{V} / \mathrm{mV}$ |
| Common-Mode Rejection | CMR | $\mathrm{V}_{\mathrm{CM}}= \pm .13 .5 \mathrm{~V}$ | 114 | 132 | - | 110 | 132 | - | dB |
| Power-Supply Rejection | PSR | $V_{S}= \pm 2 \mathrm{~V}$ to $\pm 20 \mathrm{~V}$ | 114 | 132 | - | 110 | 132 | - | dB |
| Input Voltage Range | IVR | (Note 1) | $\pm 13.5$ | $\pm 14.0$ | - | $\pm 13.5$ | $\pm 14.0$ | - | V |
| Output Voltage Swing | $\mathrm{V}_{\mathrm{o}}$ | $R_{L}=10 \mathrm{k} \Omega$ | $\pm 13$ | $\pm 14$ | - | $\pm 13$ | $\pm 14$ | - | V |
| Slew Rate | SR |  | 0.1 | 0.2 | - | 0.1 | 0.2 | - | $\mathrm{V} / \mu \mathrm{s}$ |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted. (Continued.)

| PARAMETER | SYMBOL | CONDITIONS | OP-97A/E |  |  | OP-97F |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Differential Input Resistance | $\mathrm{R}_{\text {IN }}$ | (Note 4) | 30 | - | - | 30 | - | - | $\mathrm{M} \Omega$ |
| Closed-Loop Bandwidth | BW | $\mathrm{A}_{\mathrm{VCL}}=+1$ | 0.4 | 0.9 | - | 0.4 | 0.9 | - | MHz |
| Supply Current | $\mathrm{I}_{\text {SY }}$ |  | - | 380 | 600 | - | 380 | 600 | $\mu \mathrm{A}$ |
| Supply Voltage | $\mathrm{V}_{\mathrm{S}}$ | Operating Range | $\pm 2$ | $\pm 15$ | $\pm 20$ | $\pm 2$ | $\pm 15$ | $\pm 20$ | V |

## NOTES:

1. Guaranteed by CMR test.
2. 10 Hz noise voltage density is sample tested. Devices $100 \%$ tested for noise are available on request.
3. Sample tested.
4. Guaranteed by design.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ for the OP-97E/F and $-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ for the OP-97A, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-97A/E |  |  | OP-97F |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Input Offset Voltage | $V_{\text {os }}$ |  | - | 25 | 60 | - | 60 | 200 | $\mu \mathrm{V}$ |
| Average Temperature Coefficient of $\mathrm{V}_{\text {OS }}$ | $\mathrm{TCV}_{\text {os }}$ | S-Package | - | 0.2 - | 0.6 | - | $\begin{aligned} & 0.3 \\ & 0.3 \end{aligned}$ | 2.0 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current | 'os |  | - | 60 | 250 | - | 80 | 750 | pA |
| $\begin{aligned} & \text { Average Temperature } \\ & \text { Coefficient of I OS } \\ & \hline \end{aligned}$ | $\mathrm{TCl}_{\mathrm{os}}$ |  | - | 0.4 | 2.5 | - | 0.6 | 7.5 | $\mathrm{pA} /{ }^{\circ} \mathrm{C}$ |
| Input Bias Current | $I_{B}$ |  | - | $\pm 60$ | $\pm 250$ | - | $\pm 80$ | $\pm 750$ | pA |
| Average Temperature Coefficient of $I_{B}$ | $\mathrm{TCl}_{\mathrm{B}}$ |  | - | 0.4 | 2.5 | - | 0.6 | 7.5 | $\mathrm{pA} /{ }^{\circ} \mathrm{C}$ |
| Large-Signal Voltage Gain | Avo | $V_{O}=+10 \mathrm{~V} ; \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | 200 | 1000 | - | 150 | 1000 | - | $\mathrm{V} / \mathrm{mV}$ |
| Common-Mode Rejection | CMR | $V_{C M}= \pm 13.5 \mathrm{~V}$ | 108 | 128 | - | 108 | 128 | - | dB |
| Power-Supply Rejection | PSR | $V_{S}= \pm 2.5 \mathrm{~V}$ to $\pm 20 \mathrm{~V}$ | 108 | 126 | - | 108 | 128 | - | dB |
| Input Voltage Range | IVR | (Note 1) | $\pm 13.5$ | $\pm 14.0$ | - | $\pm 13.5$ | $\pm 14.0$ | - | V |
| Output Voltage Swing | $V_{0}$ | $R_{L}=10 \mathrm{k} \Omega$ | $\pm 13$ | $\pm 14$ | - | $\pm 13$ | $\pm 14$ | - | V |
| Slew Rate | SR |  | 0.05 | 0.15 | - | 0.05 | 0.15 | - | $\mathrm{V} / \mu \mathrm{s}$ |
| Supply Current | $I_{S Y}$ |  | - | 400 | 800 | - | 400 | 800 | $\mu \mathrm{A}$ |
| Supply Voltage | $V_{S}$ | Operating Range | $\pm 2.5$ | $\pm 15$ | $\pm 20$ | $\pm 2.5$ | $\pm 15$ | $\pm 20$ | V |

## NOTES:

1. Guaranteed by CMR test.

## FEATURES

Single- or Dual-Supply Operation
Low Noise: 4.7 nV/ $\sqrt{\mathrm{Hz}}$ @ 1 kHz
Wide Bandwidth: 3.4 MHz
Low Offset Voltage: $100 \mu \mathrm{~V}$
Very Low Drift: $0.2 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$
Unity Gain Stable
No Phase Reversal

## APPLICATIONS

Digital Scales
Multimedia
Strain Gages
Battery Powered Instrumentation
Temperature Transducer Amplifier

## GENERAL DESCRIPTION

The OP-113 family dual operational amplifier features the lowest noise and drift of any single-supply amplifier. It has been designed for systems with internal calibration. Often these processor based systems are capable of calibrating corrections for offset and gain, but they cannot correct for temperature drifts and noise. Optimized for these parameters, the OP-113 family can be used to take advantage of superior analog performance combined with digital correction. Many systems using internal calibration operate from unipolar supplies, usually either +5 volts or +12 volts. The OP-113 family is designed to operate from single supplies from +4 volts to +36 volts, and to maintain its low noise and precision performance.
The OP-113 family is unity gain stable and has a typical gain bandwidth product of 3.4 MHz . Slew rate is in excess of $1 \mathrm{~V} / \mu \mathrm{s}$. Noise density is a very low $4.7 \mathrm{nV} / \sqrt{\mathrm{Hz}}$, and noise in the 0.1 Hz to 10 Hz band is 120 nV p-p. Input offset voltage is guaranteed and offset drift is guaranteed to be less than $0.8 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$. Input common-mode range includes the negative supply and to within 1 volt of the positive supply over the full supply range. Phase reversal protection is designed into the OP-113 family for cases where input voltage range is exceeded. Output voltage swings also include the negative supply and go to within 1 volt of the positive rail. The output is capable of sinking and sourcing current throughout its range and is specified with $600 \Omega$ loads.
Digital scales and other strain gage applications benefit from the very low noise and low drift of the OP-113 family. Other applications include use as a buffer or amplifier for both A/D and D/A sigma-delta converters. Often these converters have high resolutions requiring the lowest noise amplifier to utilize their full potential. Many of these converters operate in either singlesupply or low-supply voltage systems, and attaining the greater signal swing possible increases system performance. No other

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single supply amplifier provides better performance for these applications.

The OP-113 family is specified for single +5 volt and dual $\pm 15$ volt operation over the XIND-extended industrial $\left(-40^{\circ} \mathrm{C}\right.$ to $+85^{\circ} \mathrm{C}$ ) temperature range. They are available in plastic and ceramic 8-pin DIPs, plus SOIC-8 surface mount packages.
Contact your local sales office for MIL-STD-883 data sheet and availability.
$\left(@ V_{S}= \pm 15.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right.$ unless otherwise noted)


[^183]
## ELECTRICAL CHARACTERISTICS <br> (@ $V_{S}=+5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)

|  |  |  | OP-213E |  |  | OP-213F |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Parameter | Symbol | Conditions | Min | Typ | Max | Min | Typ | Max |  |
| INPUT CHARACTERISTICS |  |  |  |  |  |  |  |  |  |
| Offset Voltage | $\mathrm{V}_{\mathrm{Os}}$ | OP-113 |  |  | 125 |  |  | 175 | $\mu \mathrm{V}$ |
|  |  | $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ |  |  | 175 |  |  | 250 | $\mu \mathrm{V}$ |
|  |  | OP-213 |  |  | 150 |  |  | 300 | $\mu \mathrm{V}$ |
|  |  | $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ |  |  | 225 |  |  | 375 | $\mu \mathrm{V}$ |
|  |  | OP-413 |  |  | 175 |  |  | 325 | $\mu \mathrm{V}$ |
|  |  | $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ |  |  | 250 |  |  | 400 | $\mu \mathrm{V}$ |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=2$ |  | 300 | 650 |  |  | 650 | nA |
|  |  | $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ |  |  | 750 |  |  | 750 | nA |
| Input Offset Current | $\mathrm{I}_{\mathrm{OS}}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{OUT}}=2$ |  |  |  |  |  |  |  |
|  |  | $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ |  |  | 50 |  |  | 50 | nA |
| Input Voltage Range Common-Mode Rejection | $\mathrm{V}_{\mathrm{CM}}$ |  | 0 |  | +4 |  |  | +4 | V |
|  | CMR | $0 \leq \mathrm{V}_{\mathrm{CM}} \leq 4 \mathrm{~V}$ | 93 | 106 |  | 90 |  |  | dB |
|  |  | $0 \leq \mathrm{V}_{\mathrm{CM}} \leq 4 \mathrm{~V}$ |  |  |  |  |  |  |  |
| Large Signal Voltage Gain |  | $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ | 90 |  |  | 87 |  |  | dB |
|  | $\mathrm{A}_{\mathrm{vo}}$ | OP-113, OP-213, $\mathrm{R}_{\mathrm{L}}=600,2 \mathrm{k}$ |  |  |  |  |  |  |  |
|  |  | $0.01 \mathrm{~V} \leq \mathrm{V}_{\text {OUT }} \leq 3.9 \mathrm{~V}$ | 2 |  |  | 2 |  |  | $\mathrm{V} / \mu \mathrm{V}$ |
|  |  | OP-413, $\mathrm{R}_{\mathrm{L}}=600,2 \mathrm{k}$ |  |  |  |  |  |  |  |
|  |  | $0.01 \mathrm{~V} \leq \mathrm{V}_{\text {OUT }} \leq 3.9 \mathrm{~V}$ | 1 |  |  | 1 |  |  | $\mathrm{V} / \mu \mathrm{V}$ |
| Long Term Offset Voltage ${ }^{1}$Offset Voltage Drift | $\mathrm{V}_{\mathrm{Os}}$ | Note 1 |  |  | 200 |  |  | 350 |  |
|  | $\Delta \mathrm{V}_{\text {OS }} / \Delta \mathrm{T}$ | Note 2 |  | 0.2 | 1.0 |  |  | 1.5 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| OUTPUT CHARACTERISTICS Output Voltage Swing High |  |  |  |  |  |  |  |  |  |
|  | $\mathrm{V}_{\mathrm{OH}}$ | $\mathrm{R}_{\mathrm{L}}=600 \Omega$ | 4.0 |  |  | 4.0 |  |  | V |
|  |  | $\mathrm{R}_{\mathrm{L}}=100 \mathrm{k} \Omega,-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ | 4.1 |  |  | 4.1 |  |  | V |
|  |  | $\mathrm{R}_{\mathrm{L}}=600 \Omega,-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ | 3.9 |  |  | 3.9 |  |  | V |
| Output Voltage Swing Low | $\mathrm{V}_{\mathrm{OL}}$ | $\mathrm{R}_{\mathrm{L}}=600 \Omega$ |  |  |  |  |  |  | mV |
|  |  | $\mathrm{R}_{\mathrm{L}}=100 \mathrm{k} \Omega$ |  |  | 3.5 |  |  | 3.5 | mV |
|  |  | $\mathrm{R}_{\mathrm{L}}=600 \Omega,-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ |  |  | 4.0 |  |  | 4.0 | mV |
|  |  | $\mathrm{R}_{\mathrm{L}}=100 \mathrm{k} \Omega,-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ |  |  | 5.0 |  |  | 5.0 | mV |
| Short Circuit Limit | $\mathrm{I}_{\mathrm{SC}}$ |  |  | $\pm 30$ |  |  | $\pm 30$ |  | mA |
| POWER SUPPLY |  |  |  |  |  |  |  |  |  |
| Supply Current | $\mathrm{I}_{\text {SY }}$ | $\mathrm{V}_{\text {OUT }}=2.0 \mathrm{~V}$, No Load |  | 1.35 | 1.75 |  |  | 1.75 | mA |
| Supply Current | $\mathrm{I}_{\text {SY }}$ | $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ |  |  | 2.0 |  |  | 2.0 | mA |
| AUDIO PERFORMANCE |  |  |  |  |  |  |  |  |  |
| THD + Noise |  | $\mathrm{V}_{\text {OUT }}=0 \mathrm{dBu}, \mathrm{f}=1 \mathrm{kHz}$ |  | 0.001 |  |  | 0.001 |  |  |
| Voltage Noise Density | $\mathrm{e}_{\mathrm{n}}$ | $\mathrm{f}=10 \mathrm{~Hz}$ |  | 9 |  |  | 9 |  | $\mathrm{nV} / \sqrt{\overline{\mathrm{Hz}}}$ |
| Voltage Noise Density | $\mathrm{e}_{\mathrm{n}}$ | $\mathrm{f}=1 \mathrm{kHz}$ |  | 4.7 |  |  | 4.7 |  | $\mathrm{nV} / \sqrt{\underline{\mathrm{Hz}}}$ |
| Current Noise Density | $\mathrm{i}_{\mathrm{n}}$ | $\mathrm{f}=1 \mathrm{kHz}$ |  | 0.45 |  |  | 0.45 |  | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
| Voltage Noise | $e_{n} \mathrm{p}-\mathrm{p}$ | 0.1 Hz to 10 Hz |  | 120 |  |  | 120 |  | nV p-p |
| DYNAMIC PERFORMANCE |  |  |  |  |  |  |  |  |  |
| Slew Rate | SR | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | 0.6 | 0.9 |  | 0.6 |  |  | V/ $/ \mathrm{s}$ |
| Gain Bandwidth Product | GBP |  |  | 3.5 |  |  | 3.5 |  | MHz |
| Settling Time | $\mathrm{t}_{\text {S }}$ | to $0.1 \%, 2 \mathrm{~V}$ Step |  | 5.8 |  |  | 5.8 |  | $\mu \mathrm{s}$ |

## NOTES

${ }^{1}$ Long term offset voltage is guaranteed by a 1000 hour life test performed on three independent lots at $120^{\circ} \mathrm{C}$, with an LTPD of 1.3 .
${ }^{2}$ Guaranteed specifications, based on characterization data.
Specifications subject to change without notice.

WAFER TEST LIMITS
(@ $V_{S}=+5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)

| Parameter | Symbol | Conditions | Limit | Units |
| :---: | :---: | :---: | :---: | :---: |
| Offset Voltage | $\mathrm{V}_{\text {Os }}$ | $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}$ $\mathrm{~V}_{\text {CM }}=0, \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V}$ | $\pm 100$ +150 | $\mu \mathrm{V}$ max |
|  |  | $\mathrm{V}_{\mathrm{CM}}=0, \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V}$ | $\pm 150$ | $\mu \mathrm{V}$ max |
| Input Bias Current | $\mathrm{I}_{\text {B }}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | 650 | $n A$ max |
| Input Offset Current | $\mathrm{I}_{\mathrm{OS}}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | 50 | nA max |
| Input Voltage Range ${ }^{1}$ |  |  | 0 to 4 | $V$ min |
| Common-Mode Rejection | CMRR | $0 \leq \mathrm{V}_{\mathrm{CM}} \leq 4 \mathrm{~V}$ | 90 | dB min |
| Power Supply Rejection Ratio | PSRR | $\mathrm{V}_{\mathrm{S}}= \pm 2 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | 100 | $\mu \mathrm{V} / \mathrm{V}$ |
| Large Signal Voltage Gain | $\mathrm{A}_{\text {vo }}$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}$ | 2 | $\mathrm{V} / \mu \mathrm{V}$ min |
| Output Voltage Swing High | $\mathrm{V}_{\mathrm{OH}}$ | $\mathrm{R}_{\mathrm{L}}=600 \Omega$ | 4.0 | V min |
| Supply Current/Amplifier | $\mathrm{I}_{\text {SY }}$ | $\mathrm{V}_{\mathrm{O}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=\infty, \mathrm{V}_{\mathrm{S}}, \mathrm{V}_{\mathrm{S}}= \pm 18 \mathrm{~V}$ | 2.0 | mA max/amp |

NOTES
Electrical tests and wafer probe to the limits shown. Due to variations in assembly methods and normal yield loss, yield after packaging is not guaranteed for standard product dice. Consult factory to negotiate specifications based on dice lot qualifications through sample lot assembly and testing.
${ }^{1}$ Guaranteed by CMR test.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

| Supply Voltage |  |
| :---: | :---: |
| Input Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 18$ V |  |
| Differential Input Voltage . . . . . . . . . . . . . . . . . . . $\pm 10 \mathrm{~V}$ |  |
| Output Short-Circuit Duration to GND . . . . . . . . . Indefinite |  |
| Storage Temperature Range |  |
| Z, Y Package . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+175^{\circ} \mathrm{C}$ |  |
| P, S Package . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |  |
| Operating Temperature Range |  |
| OP-113/OP-213/OP-413A, B . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ OP-113/OP-213/OP-413E, F . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |
|  |  |
| Junction Temperature Range |  |
| Z, Y Package . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |  |
| P, S Package . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |  |
| Lead Temperature Range (Soldering, 60 | $+300^{\circ} \mathrm{C}$ |


| Package Type | $\boldsymbol{\theta}_{\mathbf{J A}}{ }^{\mathbf{2}}$ | $\boldsymbol{\theta}_{\mathbf{J C}}$ | Units |
| :--- | :--- | :--- | :--- |
| 8-Pin Cerdip (Z) | 148 | 16 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin Plastic DIP (P) | 103 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin SOIC (S) | 158 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 14-Pin Cerdip (Y) | 108 | 16 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 14-Pin Plastic DIP (P) | 83 | 39 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 16-Pin SOL (S) | 92 | 27 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTES

${ }^{1}$ Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
${ }^{2} \theta_{\mathrm{JA}}$ is specified for the worst case conditions, i.e., $\theta_{\mathrm{JA}}$ is specified for device in socket for cerdip, P-DIP, and LCC packages; $\theta_{\mathrm{JA}}$ is specified for device soldered in circuit board for SOIC package.

DICE CHARACTERISTICS


ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| OP113AZ/883 | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Cerdip | Q-8 |
| OP113BZ/883 | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Cerdip | Q-8 |
| OP113EZ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Cerdip | Q-8 |
| OP113EP | $-40^{\circ}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | N-8 |
| OP113ES | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin SOIC | SO-8 |
| OP113FP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | N-8 |
| OP113FS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin SOIC | SO-8 |
| OP113GBC | $+25^{\circ} \mathrm{C}$ | DICE |  |
| OP213AZ/883 | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Cerdip | Q-8 |
| OP213BZ/883 | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Cerdip | Q-8 |
| OP213EZ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Cerdip | Q-8 |
| OP213EP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | N-8 |
| OP213ES | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin SOIC | SO-8 |
| OP213FP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | $\mathrm{N}-8$ |
| OP213FS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin SOIC | SO-8 |
| OP213GBC | $+25^{\circ} \mathrm{C}$ | DICE |  |
| OP413AY/883 | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 14-Pin Cerdip | Q-14 |
| OP413BY/883 | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 14-Pin Cerdip | $\mathrm{Q}-14$ |
| OP413EY | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 14-Pin Cerdip | Q-14 |
| OP413EP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 14-Pin Plastic DIP | N-14 |
| OP413ES | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 16-Pin SOL | SOL-16 |
| OP413FP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 14-Pin Plastic DIP | N-14 |
| OP413FS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 16-Pin SOL | SOL-16 |
| OP413GBC | $+25^{\circ} \mathrm{C}$ | DICE |  |

*For outline information see Package Information section.


OP-213 Die Size $0.062 \times 0.097$ inch, 6,014 sq. mils. Substrate (Die Backside) Is Connected to V+. Transistor Count, 132.


OP-413 Die Size $0.106 \times 0.106$ inch, 10,176 sq. mils. Substrate (Die Backside) Is Connected to V+. Transistor Count, 256.

## APPLICATIONS

The OP-113, OP-213 and OP-413 form a new family of high performance amplifiers that feature precision performance in standard dual supply configurations, and, more importantly, maintain precision performance when a single power supply is used. In addition to accurate dc specifications, it is the lowest noise single supply amplifier available with only $4.7 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ typical noise density.
Single supply applications have special requirements due to the generally reduced dynamic range of the output signal. Single supply applications are often operated at voltages of +5 volts or +12 volts, compared to dual supply applications with supplies of $\pm 12$ volts or $\pm 15$ volts. This results in reduced output swings. Where a dual supply application may often have 20 volts of signal output swing, single supply applications are limited to at most the supply range, and more commonly several volts below the supply. In order to attain the greatest swing the single supply output stage must swing closer to the supply rails than in dual supply applications.
The OP-113 family has a new patented output stage that allows the output to swing closer to ground, or the negative supply,
than previous bipolar output stages. Previous op amps had outputs that could swing to within about ten millivolts of the negative supply in single supply applications. However the OP-113 family combines both a bipolar and a CMOS device in the output stage, enabling it to swing to within a few hundred microvolts of ground.
When operating with reduced supply voltages, the input range is also reduced. This reduction in signal range results in reduced signal-to-noise ratio, for any given amplifier. There are only two ways to improve this; increase the signal range or reduce the noise. The OP-113 family addresses both of these parameters. Input signal range is from the negative supply to within one volt of the positive supply over the full supply range. Competitive parts have input ranges that are a half a volt to five volts less than this. Noise has also been optimized in the OP-113 family. At $4.7 \mathrm{nV} /$ $\sqrt{\mathrm{Hz}}$, it is less than one fourth that of competitive devices.

## Phase Reversal

The OP-113 family is protected against phase reversal as long as both of the inputs are within the supply ranges. However, if there is a possibility of either input going below the negative supply (or ground in the single supply case), then the inputs should be protected with a series resistor to limit input current to 2 mA .
OP-113 Offset Adjust
The OP-113 has the facility for external offset adjustment, using the industry standard arrangement. Pins 1 and 5 are used in conjunction with a potentiometer of $10 \mathrm{k} \Omega$ total resistance, connected with the wiper to $\mathrm{V}-$ (or ground in single supply applications). The total adjustment range is about $\pm 2 \mathrm{mV}$ using this configuration.
Adjusting the offset to zero has minimal effect on offset drift (assuming the potentiometer has a tempco of less than $1000 \mathrm{ppm} /$ ${ }^{\circ} \mathrm{C}$ ). Adjustment away from zero, however, (like all bipolar amplifiers) will result in a $\mathrm{TCV}_{\mathrm{Os}}$ of approximately $3.3 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ for every millivolt of induced offset.

It is, therefore, not generally recommended that this trim be used to compensate for system errors originating outside of the OP-113. The initial offset of the OP-113 is low enough that external trimming is almost never required, but if necessary, the 2 mV trim range may be somewhat excessive. Reducing the trimming potentiometer to a $2 \mathrm{k} \Omega$ value will give a more reasonable range of $\pm 400 \mu \mathrm{~V}$.


Figure 1. Precision Load Cell Scale Amplifier

## APPLICATION CIRCUITS

## A High Precision Industrial Load-Cell Scale Amplifier

The OP-113 family makes an excellent amplifier for conditioning a load-cell bridge. Its low noise greatly improves the signal resolution, allowing the load cell to operate with a smaller output range, thus reducing its nonlinearity. Figure 1 shows one half of the OP-113 family used to generate a very stable 10.000 V bridge excitation voltage while the second amplifier provides a differential gain. R4 should be trimmed for maximum commonmode rejection.

## A Low Voltage Single Supply, Strain-Gage Amplifier

The true zero swing capability of the OP-113 family allows the amplifier in Figure 2 to amplify the strain-gage bridge accurately even with no signal input while being powered by a single +5 volt supply. A stable 4.000 V bridge voltage is made possible by the rail-to-rail OP-295 amplifier, whose output can swing to within a millivolt of either rail. This high voltage swing greatly increases the bridge output signal without a corresponding increase in bridge input.


Figure 2. Single Supply Strain-Gage Amplifier

## A High Accuracy Linearized RTD Thermometer Amplifier

Zero-suppressing the bridge facilitates simple linearization of the RTD by feeding back a small amount of the output signal to the RTD (Resistor Temperature Device). In Figure 3 the left leg of the bridge is servoed to a virtual ground voltage by amplifier A1, while the right leg of the bridge is also servoed to zero-volt by amplifier A2. This eliminates any error resulting from common-mode voltage change in the amplifier. A three-wire RTD is used to balance the wire resistance on both legs of the bridge, thereby reducing temperature mismatch errors. The 5.000 V bridge excitation is derived from the extremely stable AD 588 reference device with $1.5 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ drift performance.
Linearization of the RTD is done by feeding a fraction of the output voltage back to the RTD in the form of a current. With just the right amount of positive feedback, the amplifier output will be linearly proportional to the temperature of the RTD.


Figure 3. Ultraprecision RTD Amplifier
To calibrate the circuit, first immerse the RTD in a zero-degree ice bath or substitute an exact $100 \Omega$ resistor in place of the RTD. Adjust the ZERO ADJUST potentiometer for a 0.000 V output, then set R9 LINEARITY ADJUST potentiometer to the middle of its adjustment range. Substitute a $280.9 \Omega$ resistor (equivalent to $500^{\circ} \mathrm{C}$ ) in place of the RTD, and adjust the FULL-SCALE ADJUST potentiometer for a full-scale voltage of 5.000 V .

To calibrate out the nonlinearity, substitute a $194.07 \Omega$ resistor (equivalent to $250^{\circ} \mathrm{C}$ ) in place of the RTD, then adjust the LINEARITY ADJUST potentiometer for a 2.500 V output. Check and readjust the full-scale and half-scale as needed.
Once calibrated, the amplifier outputs a $10 \mathrm{mV} /{ }^{\circ} \mathrm{C}$ temperature coefficient with an accuracy better than $\pm 0.5^{\circ} \mathrm{C}$ over an RTD measurement range of $-150^{\circ} \mathrm{C}$ to $+500^{\circ} \mathrm{C}$. Indeed the amplifier can be calibrated to a higher temperature range, up to $850^{\circ} \mathrm{C}$.

## A High Accuracy Thermocouple Amplifier

Figure 4 shows a popular K-type thermocouple amplifier with cold-junction compensation. Operating from a single +12 volt supply, the OP- 113 family's low noise allows temperature measurement to better than $0.02^{\circ} \mathrm{C}$ resolution from $0^{\circ} \mathrm{C}$ to $1000^{\circ} \mathrm{C}$ range. The cold-junction error is corrected by using an inexpensive silicon diode as a temperature measuring device. It should be placed as close to the two terminating junctions as physically possible. An aluminum block might serve well as an isothermal system.

Figure 4. Accurate K-Type Thermocouple Amplifier


## OP113/OP213/0P413

R6 should be adjusted for a zero-volt output with the thermocouple measuring tip immersed in a zero-degree ice bath. When calibrating, be sure to adjust R6 initially to cause the output to swing in the positive direction first. Then back off in the negative direction until the output just stops changing.

## An Ultralow Noise, Single Supply Instrumentation Amplifier

 Extremely low noise instrumentation amplifiers can be built using the OP-113 family. Such an amplifier that operates off a single supply is shown in Figure 5. Resistors R1-R5 should be of high precision and low drift type to maximize CMRR performance. Although the two inputs are capable of operating to zero volt, the gain of -100 configuration will limit the amplifier input common mode to not less than 0.33 V .

Figure 5. Ultralow Noise, Single Supply Instrumentation Amplifier

## Supply Splitter Circuit

The OP-113 family has excellent frequency response characteristic that makes it an ideal pseudo-ground reference generator as shown in Figure 6. The OP-113 family serves as a voltage follower buffer. In addition, it drives a large capacitor that serves as a charge reservoir to minimize transient load changes, as well as a low impedance output device at high frequencies. The circuit easily supplies 25 mA load current with good settling characteristics.


Figure 6. False Ground Generator

## Low Noise Voltage Reference

Few reference devices combine low noise and high output drive capabilities. Figure 7 shows the OP-113 family used as a twopole active filter that band limits the noise of the 2.500 V reference. Total noise measures $3 \mu \mathrm{~V}$ p-p.


Figure 7. Low Noise Voltage Reference
+5 V Only Stereo DAC For Multimedia
The OP-113 family's low noise and single supply capability are ideally suited for stereo DAC audio reproduction or sound synthesis applications such as multimedia systems. Figure 8 shows an 18 -bit stereo DAC output setup that is powered from a single +5 volt supply. The low noise preserves the 18 -bit dynamic range of the AD1868. For DACs that operate on dual supplies, the OP-113 family can also be powered from the same supplies.


Figure 8. +5 V Only 18-Bit Stereo DAC

## Low Voltage Headphone Amplifiers

Figure 9 shows a stereo headphone output amplifier for the AD1849 16-bit SoundPort ${ }^{\circledR}$ Stereo Codec device. The pseudoreference voltage is derived from the common-mode voltage generated internally by the AD1849, thus providing a convenient bias for the headphone output amplifiers.

SoundPort is a registered trademark of Analog Devices, Inc.


Figure 9. Headphone Output Amplifier for Multimedia Sound Codec

## Low Noise Microphone Amplifier for Multimedia

The OP-113 family is ideally suited as a low noise microphone preamp for low voltage audio applications. Figure 10 shows a gain of 100 stereo preamp for the AD1849 16-bit SoundPort Stereo Codec chip. The common-mode output buffer serves as a "phantom power" driver for the microphones.


Figure 10. Low Noise Stereo Microphone Amplifier for Multimedia Sound Codec

## Precision Voltage Comparator

With its PNP inputs and zero volt common-mode capability, the OP-113 family can make useful voltage comparators. There is only a slight penalty in speed in comparison to IC comparators. However, the significant advantage is its voltage accuracy. For example, $\mathrm{V}_{\mathrm{OS}}$ can be a few hundred microvolts or less, combined with CMRR and PSRR exceeding 100 dB , while operating on 5 V supply. Standard comparators like the $111 / 311$ family operate on 5 volts, but not with common-mode at ground, nor with offset below 3 mV . Indeed no commercially available single supply comparator has a $\mathrm{V}_{\mathrm{OS}}$ less than $200 \mu \mathrm{~V}$.
Figure 11 shows the OP-113 family response to a 10 mV overdrive signal when operating in open loop. The top trace shows the output rising edge has a $15 \mu \mathrm{~s}$ propagation delay, while the bottom trace shows a $7 \mu \mathrm{~s}$ delay on the output falling edge. This ac response is quite acceptable in many applications.



Figure 11. Precision Comparator
The low noise and $250 \mu \mathrm{~V}$ (maximum) offset voltage enhance the overall dc accuracy of this type of comparator. Note that zero crossing detectors and similar ground referred comparisons can be implemented even if the input swings to -0.3 volts below ground.


Figure 12a. OP-113 Input Offset $\left(V_{\text {os }}\right)$ Distribution @ $\pm 15$ V


Figure 12b. OP-213 Input Offset ( $V_{\text {OS }}$ ) Distribution @ $\pm 15$ V


Figure 12c. OP-413 Input Offset ( $V_{\text {OS }}$ ) Distribution @ $\pm 15$ V


Figure 13a. OP-113 Temperature Drift ( $\mathrm{TCV}_{\text {OS }}$ ) Distribution@ $\pm 15$ V


Figure 13b. OP-213 Temperature Drift ( $\mathrm{TCV}_{\text {os }}$ ) Distribution @ $\pm 15$ V


Figure 13c. OP-413 Temperature Drift (TCV ${ }_{\text {OS }}$ ) Distribution @ $\pm 15$ V


Figure 14. OP-113 Input Bias Current vs. Temperature


Figure 15. Output Swing vs.Temperature and $R_{L} @+5 V$


Figure 16. Channel Separation


Figure 17. OP-213 Input Bias Current vs. Temperature


Figure 18. Output Swing vs. Temperature and $R_{L} @ \pm 15 \mathrm{~V}$


Figure 19. Open-Loop Gain vs. Temperature @ +5 V


Figure 20. OP-413 Open-Loop Gain vs. Temperature


Figure 21. Open-Loop Gain, Phase vs. Frequency @ +5 V


Figure 22. Closed-Loop Gain vs. Frequency @ +5 V


Figure 23. OP-213 Open-Loop Gain vs. Temperature


Figure 24. Open-Loop Gain Phase vs. Frequency @ $\pm 15$ V


Figure 25. Closed-Loop Gain vs. Frequency @ $\pm 15$ V


Figure 26. Gain Bandwidth Product and Phase Margin vs. Temperature@+5 V


Figure 27. Voltage Noise Density vs. Frequency


Figure 28. Common-Mode Rejection vs. Frequency @ +5 V


Figure 29. Gain Bandwidth Product and Phase Margin vs. Temperature @ $\pm 15$ V


Figure 30. Current Noise Density vs. Frequency


Figure 31. Common-Mode Rejection vs. Frequency $@ \pm 15$ V


Figure 32. Power Supply Rejection vs. Frequency @ $\pm 15$ V


Figure 33. Maximum Output Swing vs. Frequency @ +5 V


Figure 34. Small Signal Overshoot vs. Load Capacitance @ +5 V


Figure 35. Closed-Loop Output Impedance vs. Frequency $@+15$ V


Figure 36. Maximum Output Swing vs. Frequency @ $\pm 15$ V


Figure 37. Small Signal Overshoot vs. Load Capacitance $@ \pm 15$ V


Figure 38. Slew Rate vs. Temperature @ +5 V ( $0.5 \mathrm{~V} \leq V_{\text {OUT }} \leq+4.0 \mathrm{~V}$ )


Figure 39. Input Voltage Noise @ $\pm 15$ V (20 nV/div)


Figure 40. Noise Test Diagram


Figure 41. Slew Rate vs. Temperature $@ \pm 15 \mathrm{~V}$ ( $-10 \mathrm{~V} \leq V_{\text {OUT }} \leq+10.0 \mathrm{~V}$ )


Figure 42. Input Voltage Noise @ +5 V (20 nV/div)


Figure 43. Supply Current vs. Temperature


Figure 44. OP-213 Simplified Schematic


* SECOND CURRENT NOISE SOURCE

| DN5 | 27 | 28 | DIN |
| :--- | :--- | :--- | :--- |
| DN6 | 28 | 29 | DIN |
| VN5 | 27 | 0 | DC 2 |
| VN6 | 0 | 29 | DC 2 |
| * |  |  |  |
| * GAIN STAGE \& DOMINANT POLE AT $.2000 E+01 ~ H Z ~$ |  |  |  |


| G2 | 34 | 36 | 19 | 20 |
| :--- | ---: | ---: | :--- | :--- |
| R7 | 34 | 36 | $39 \mathrm{E}+06$ |  |
| V3 | 35 | 4 | DC | 6 |
| D4 | 36 | 35 | DX |  |
| VB2 | 34 | 4 | 1.6 |  |
| $\star$ |  |  |  |  |
| $\star$ |  |  |  |  |
| SUPPLY/2 | GENERATOR |  |  |  |
| ISY | 7 | 4 | $0.2 \mathrm{E}-3$ |  |
| R10 | 7 | 60 | $40 \mathrm{E}+3$ |  |
| R11 | 60 | 4 | $40 \mathrm{E}+3$ |  |
| C3 | 60 | 0 | $1 \mathrm{E}-9$ |  |

* CMRR STAGE \& POLE AT 6 kHZ
$\begin{array}{llllllllllll}\text { ECM } & 50 & 4 & \text { POLY(2) } & 3 & 60 & 2 & 60 & 0 & 1.6 & 0 & 1.6\end{array}$
CCM $505051 \quad 26.5 \mathrm{E}-12$
RCM1 $50 \quad 51 \quad 1 E 6$
$\begin{array}{llll}\text { RCM2 } & 51 & 4 & 1\end{array}$
$\star$

OUTPUT STAGE
$\begin{array}{llll}\text { R12 } & 37 & 36 & \text { 1E3 }\end{array}$
$\begin{array}{lllll}\text { R13 } & 38 & 36 & 500\end{array}$
C4 $\quad \begin{array}{llll}37 & 6 & 20 \mathrm{E}-12\end{array}$
C5 $\quad 38 \quad 39 \quad 20 \mathrm{E}-12$
$\begin{array}{lllll}\mathrm{M} 1 & 39 & 36 & 4 & 4 \mathrm{MN} \mathrm{L}=9 \mathrm{E}-6 \mathrm{~W}=1000 \mathrm{E}-6 \mathrm{AD}=15 \mathrm{E}-9 \mathrm{AS}=15 \mathrm{E}-9\end{array}$
M2 $45 \quad 3644 \mathrm{MNL}=9 \mathrm{E}-6 \mathrm{~W}=1000 \mathrm{E}-6 \mathrm{AD}=15 \mathrm{E}-9 \mathrm{AS}=15 \mathrm{E}-9$
D5 3947 DX
D6 4745 DX
Q3 $\quad 39 \quad 40 \quad 41 \quad$ QPA 8
$\begin{array}{lllll}\text { VB } & 7 & 40 & \text { DC } & 0.861\end{array}$
$\begin{array}{llll}\text { R14 } & 7 & 41 & 375\end{array}$
Q4 $41 \begin{array}{llll}7 & 43 & \text { QNA } 1\end{array}$
$\begin{array}{llll}\text { R17 } & 7 & 43 & 15\end{array}$
Q5 $\quad 43 \quad 39 \quad 6 \quad$ QNA 20
Q6 $\quad 46 \quad 45 \quad 6 \quad$ QPA 20
$\begin{array}{llll}\text { R18 } & 46 & 4 & 15\end{array}$
Q7 $\quad 36 \quad 46 \quad 4 \quad$ QNA 1
M3 $63644 \mathrm{MNL}=9 \mathrm{E}-6 \mathrm{~W}=2000 \mathrm{E}-6 \mathrm{AD}=30 \mathrm{E}-9 \mathrm{AS}=30 \mathrm{E}-9$
*

* NONLINEAR MODELS USED
* 

.MODEL DX D (IS=1E-15)
.MODEL DY D ( $\mathrm{IS}=1 \mathrm{E}-15 \mathrm{BV}=7$ )
.MODEL PNPI PNP ( $\mathrm{BF}=220$ )
. MODEL DEN D(IS $=1 \mathrm{E}-12 \mathrm{RS}=1016 \mathrm{KF}=3.278 \mathrm{E}-15 \mathrm{AF}=1$ )
.MODEL DIN $\mathrm{D}(\mathrm{IS}=1 \mathrm{E}-12 \mathrm{RS}=100019 \mathrm{KF}=4.173 \mathrm{E}-15 \mathrm{AF}=1$ )
. MODEL QNA NPN $(\mathrm{IS}=1.19 \mathrm{E}-16 \mathrm{BF}=253 \mathrm{VAF}=193 \mathrm{VAR}=15 \mathrm{RB}=2.0 \mathrm{E} 3$
$+\mathrm{IRB}=7.73 \mathrm{E}-6 \mathrm{RBM}=132.8 \mathrm{RE}=4 \mathrm{RC}=209 \mathrm{CJE}=2.1 \mathrm{E}-13 \mathrm{VJE}=0.573$
$+\mathrm{MJE}=0.364 \mathrm{CJC}=1.64 \mathrm{E}-13 \mathrm{VJC}=0.534 \mathrm{MJC}=0.5 \mathrm{CJS}=1.37 \mathrm{E}-12$
$+\mathrm{VJS}=0.59 \mathrm{MJS}=0.5 \mathrm{TF}=0.43 \mathrm{E}-9 \mathrm{PTF}=30$ )
. MODEL QPA PNP(IS $=5.21 \mathrm{E}-17 \mathrm{BF}=131 \mathrm{VAF}=62 \mathrm{VAR}=15 \mathrm{RB}=1.52 \mathrm{E} 3$
$+\mathrm{IRB}=1.67 \mathrm{E}-5 \mathrm{RBM}=368.5 \mathrm{RE}=6.31 \mathrm{RC}=354.4 \mathrm{CJE}=1.1 \mathrm{E}-13$
$+\mathrm{VJE}=0.745 \mathrm{MJE}=0.33 \mathrm{CJC}=2.37 \mathrm{E}-13 \mathrm{VJC}=0.762 \mathrm{MJC}=0.4$
$+\mathrm{CJS}=7.11 \mathrm{E}-13 \mathrm{VJS}=0.45 \mathrm{MJS}=0.412 \mathrm{TF}=1.0 \mathrm{E}-9 \mathrm{PTF}=30$ )
.MODEL MN NMOS(LEVEL $=3 \mathrm{VTO}=1.3 \mathrm{RS}=0.3 \mathrm{RD}=0.3 \mathrm{TOX}=8.5 \mathrm{E}-8$
$+\mathrm{LD}=1.48 \mathrm{E}-6 \mathrm{WD}=1 \mathrm{E}-6 \mathrm{NSUB}=1.53 \mathrm{E} 16 \mathrm{UO}=650 \mathrm{DELTA}=10 \mathrm{VMAX}=2 \mathrm{E} 5$
$+\mathrm{XJ}=1.75 \mathrm{E}-6 \mathrm{KAPPA}=0.8 \mathrm{ETA}=0.066 \mathrm{THETA}=0.01 \mathrm{TPG}=1 \mathrm{CJ}=2.9 \mathrm{E}-4$
$+\mathrm{PB}=0.837 \mathrm{MJ}=0.407 \mathrm{CJSW}=0.5 \mathrm{E}-9 \mathrm{MJSW}=0.33$ )
*
.ENDS OP113 Family

## FEATURES

Low Noise: $6 \mathrm{nV} / \sqrt{\mathrm{Hz}}$
High Slew Rate: $25 \mathrm{~V} / \mu \mathrm{s}$
Wide Bandwidth: 10 MHz
Low Supply Current: 2.5 mA
Low Offset Voltage: 1 mV
Unity Gain Stable
SO-8 Package
APPLICATIONS
Line Driver
Active Filters
Fast Amplifiers
Integrators

## GENERAL DESCRIPTION

The OP176 is a low noise, high output drive op amp that features the Butler Amplifier front-end. This new front-end design combines both bipolar and JFET transistors to attain amplifiers with the accuracy and low noise performance of bipolar transistors, and the speed and sound quality of JFETs. Total Harmonic Distortion plus Noise equals previous audio amplifiers, but at much lower supply currents.
Improved dc performance is also provided with bias and offset currents greatly reduced over purely bipolar designs. Input offset voltage is guaranteed at 1 mV and is typically less than

## PIN CONNECTIONS

## 8-Lead Narrow-Body SO <br> (S Suffix)



8-Lead Epoxy DIP (P Suffix)

$200 \mu \mathrm{~V}$. This allows the OP176 to be used in many dc coupled or summing applications without the need for special selections or the added noise of additional offset adjustment circuitry.
The output is capable of driving $600 \Omega$ loads to 10 V rms while maintaining low distortion. THD + Noise at 3 V rms is a low $0.0006 \%$.
The OP176 is specified over the extended industrial $\left(-40^{\circ} \mathrm{C}\right.$ to $+85^{\circ} \mathrm{C}$ ) temperature range. OP176s are available in both plastic DIP and SO-8 packages. SO-8 packages are available in 2500 piece reels. Many audio amplifiers are not offered in SO-8 surface mount packages for a variety of reasons, however, the OP176 was designed so that it would offer full performance in surface mount packaging.
*Protected by U.S. Patent No. 5101126.


Simplified Schematic

## OP176-SPECIFICATIONS

ELECTRICAL CHARACTERISTICS (® $V_{3}= \pm 15.0 . T_{1}, T_{1}=+25^{\circ}$ unless otherisise noter)

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT CHARACTERISTICS <br> Offset Voltage Offset Voltage Input Bias Current Input Offset Current Input Voltage Range Common-Mode Rejection Large Signal Voltage Gain Offset Voltage Drift | $\mathrm{V}_{\mathrm{os}}$ <br> $\mathrm{V}_{\mathrm{OS}}$ <br> $\mathrm{I}_{\mathrm{B}}$ <br> $\mathrm{I}_{\mathrm{OS}}$ <br> $\mathrm{V}_{\mathrm{CM}}$ <br> CMRR <br> $\mathrm{A}_{\mathrm{vo}}$. <br> $\Delta \mathrm{V}_{\mathrm{os}} / \Delta \mathrm{T}$ | $\begin{aligned} & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{CM}}= \pm 10.5 \mathrm{~V}, \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega,-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{R}_{\mathrm{L}}=600 \Omega \end{aligned}$ | $\begin{aligned} & -10.5 \\ & 80 \\ & 250 \\ & 175 \end{aligned}$ | $\begin{aligned} & 106 \\ & 200 \\ & 5 \end{aligned}$ | $\begin{aligned} & 1 \\ & 1.25 \\ & 350 \\ & 400 \\ & \pm 50 \\ & \pm 100 \\ & +10.5 \end{aligned}$ | mV <br> mV <br> nA <br> nA <br> nA <br> nA <br> V <br> dB <br> $\mathrm{V} / \mathrm{mV}$ <br> $\mathrm{V} / \mathrm{mV}$ <br> $\mathrm{V} / \mathrm{mV}$ <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| OUTPUT CHARACTERISTICS <br> Output Voltage Swing <br> Output Short Circuit Current | $\begin{aligned} & \mathrm{V}_{\mathrm{o}} \\ & \mathrm{I}_{\mathrm{sc}} \end{aligned}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega,-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{R}_{\mathrm{L}}=600 \Omega, \mathrm{~V}_{\mathrm{S}}= \pm 18 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & -13.5 \\ & -14.8 \\ & \pm 25 \end{aligned}$ | $\pm 50$ | $\begin{aligned} & +13.5 \\ & +14.8 \end{aligned}$ | V <br> V <br> mA |
| POWER SUPPLY <br> Power Supply Rejection Ratio <br> Supply Current <br> Supply Current <br> Supply Voltage Range | PSRR <br> $\mathrm{I}_{\mathrm{SY}}$ <br> $\mathrm{I}_{\mathrm{SY}}$ <br> $\mathrm{V}_{\mathrm{s}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}= \pm 4.5 \mathrm{~V} \text { to } \pm 18 \mathrm{~V} \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 4.5 \mathrm{~V} \text { to } \pm 18 \mathrm{~V}, \mathrm{~V}_{\mathrm{O}}=0 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{L}}=\infty,-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 22 \mathrm{~V}, \mathrm{~V}_{\mathrm{O}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=\infty, \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \end{aligned}$ | 86 <br> 80 <br> $\pm 4.5$ | $108$ | $2.5$ $2.75$ $\pm 22$ | dB <br> dB <br> mA <br> mA <br> V |
| DYNAMIC PERFORMANCE <br> Slew Rate Gain Bandwidth Product | $\begin{aligned} & \text { SR } \\ & \text { GBP } \end{aligned}$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | 15 | $\begin{aligned} & 25 \\ & 10 \end{aligned}$ |  | $\mathrm{V} / \mu \mathrm{s}$ <br> MHz |
| AUDIO PERFORMANCE <br> THD + Noise <br> Voltage Noise Density Current Noise Density | $\begin{aligned} & \mathrm{e}_{\mathrm{n}} \\ & \mathrm{i}_{\mathrm{n}} \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=3 \mathrm{Vrms}, \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{f}=1 \mathrm{kHz} \\ & \mathrm{f}=1 \mathrm{kHz} \\ & \mathrm{f}=1 \mathrm{kHz} \end{aligned}$ |  | $\begin{aligned} & 0.001 \\ & 6 \\ & 0.5 \end{aligned}$ |  | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |

Specifications subject to change without notice.

WAFER TEST LIMITS © $_{\text {© }} \mathrm{V}_{\mathrm{s}}= \pm 15.0, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)

| Parameter | Symbol | Conditions | Limit | Units |
| :---: | :---: | :---: | :---: | :---: |
| Offset Voltage | $\mathrm{V}_{\text {OS }}$ |  | 1 | $m V$ max |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | 350 | $n A$ max |
| Input Offset Current | $\mathrm{I}_{\text {OS }}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | $\pm 50$ | $n A$ max |
| Input Voltage Range ${ }^{1}$ | $\mathrm{V}_{\mathrm{CM}}$ |  | $\pm 10.5$ | $V$ min |
| Common-Mode Rejection | CMRR | $\mathrm{V}_{\mathrm{CM}}= \pm 10.5 \mathrm{~V}$ | 80 | dB min |
| Power Supply Rejection Ratio | PSRR | $\mathrm{V}= \pm 4.5 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | 86 | dB min |
| Large Signal Voltage Gain | $\mathrm{A}_{\mathrm{vo}}$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | 250 | $\mathrm{V} / \mathrm{mV}$ min |
| Output Voltage Range | $\mathrm{V}_{0}$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | 13.5 | V min |
|  |  | $\mathrm{V}_{\mathrm{S}}= \pm 18.0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=600 \Omega$ | 14.8 | V min |
| Supply Current | $\mathrm{I}_{\text {SY }}$ | $\mathrm{V}_{\mathrm{S}}= \pm 22.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{o}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=\infty$ | 2.75 | mA max |
|  |  | $\begin{aligned} & \mathrm{V}_{\mathrm{s}}= \pm 4.5 \mathrm{~V} \text { to } \pm 18 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{o}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=\infty \end{aligned}$ | 2.5 | $m A \max$ |

## NOTES

Electrical tests and wafer probe to the limits shown. Due to variations in assembly methods and normal yield loss, yield after packaging is not guaranteed for standard product dice. Consult factory to negotiate specifications based on dice lot qualifications through sample lot assembly and testing.
${ }^{1}$ Guaranteed by CMR test.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

## DICE CHARACTERISTICS

| Supply Voltage | 2 V |
| :---: | :---: |
| Input Voltage ${ }^{2}$. | $\pm 18 \mathrm{~V}$ |
| Differential Input Voltage ${ }^{2}$ | $\pm 7.5 \mathrm{~V}$ |
| Output Short-Circuit Duration to GND | Indefinite |
| Storage Temperature Range |  |
| P, S Package | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Operating Temperature Range |  |
| OP176G | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Junction Temperature Range |  |
| P, S Package | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Lead Temperature Range (Soldering, 60 | $+300^{\circ} \mathrm{C}$ |


| Package Type | $\theta_{\mathrm{JA}}{ }^{3}$ | $\theta_{\mathrm{JC}}$ | Units |
| :--- | :--- | :--- | :--- |
| 8-Pin Plastic DIP (P) | 103 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin SOIC (S) | 158 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTES

${ }^{1}$ Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
${ }^{2}$ For input voltages greater than $\pm 7.5 \mathrm{~V}$ limit input current to less than 5 mA .
${ }^{3} \theta_{\mathrm{JA}}$ is specified for the worst case conditions, i.e., $\theta_{\mathrm{JA}}$ is specified for device in socket for P-DIP packages; $\theta_{\mathrm{JA}}$ is specified for device soldered in circuit board for SOIC package.


OP176 Die Size $0.069 \times 0.067$ Inch, 4,623 Sq. Mils. Substrate (Die Backside) Is Connected to $V$-. Transistor Count, 26.

ORDERING GUIDE

| Model | Temperature Range | Package Description | Package Option* |
| :--- | :--- | :--- | :--- |
| OP176GP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | N-8 |
| OP176GS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin SOIC | SO-8 |
| OP176GSR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | SO-8 Reel, 2500 Pieces |  |
| OP176GBC | $+25^{\circ} \mathrm{C}$ | DICE |  |

*For outline information see Package Information section.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the OP176 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

## OP176-Typical Characteristics



Figure 1. Input Offset Voltage Drift Distribution @ $\pm 15$ V


Figure 2. Output Swing vs. Temperature


Figure 3. Input Bias Current vs. Temperature


Figure 4. Maximum Output Swing vs. Frequency


Figure 5. Maximum Output Swing vs. Load Resistance


Figure 6. Supply Current per Amplifier vs. Supply Voltage


Figure 7. Short Circuit Current vs. Temperature @ $\pm 15$ V


Figure 8. Open-Loop Gain \& Phase vs. Frequency


Figure 9. Closed-Loop Gain vs. Frequency


Figure 10. Power Supply Rejection vs. Frequency


Figure 11. Open-Loop Gain vs. Temperature


Figure 12. Closed-Loop Output Impedance vs. Frequency


Figure 13. Common-Mode Rejection vs. Frequency


Figure 14. Small Signal Overshoot vs. Load Capacitance


Figure 15. Slew Rate vs. Differential Input Voltage


Figure 16. Gain Bandwidth Product \& Phase Margin vs. Temperature


Figure 17. Slew Rate vs. Load Capacitance


Figure 18. Slew Rate vs. Temperature


Figure 19. Voltage Noise Density vs. Frequency


Figure 20. Small Signal Transient Response


Figure 21. Current Noise Density vs. Frequency


Figure 22. Large Signal Transient Response

## APPLICATIONS

## Short Circuit Protection

The OP176 has been designed with output short circuit protection. The typical output drive current is $\pm 50 \mathrm{~mA}$. This high output current and wide output swing combine to yield an excellent audio amplifier, even when driving large signals, at low power and in a small package.

## Total Harmonic Distortion

Total Harmonic Distortion + Noise (THD + N) of the OP176 is well below $0.001 \%$ with any load down to $600 \Omega$. However, this is dependent upon the peak output swing. In Figure 23 it is seen that the THD + Noise with 3 V rms output is below $0.001 \%$. In the following Figure 24, THD + Noise is below $0.001 \%$ for the $10 \mathrm{k} \Omega$ and $2 \mathrm{k} \Omega$ loads but increases to above $0.01 \%$ for the $600 \Omega$ load condition. This is a result of the output swing capability of the OP176. Notice the results in Figure 25, showing THD vs. $\mathrm{V}_{\text {IN }}(\mathrm{V} \mathrm{rms})$.


FIGURE 23. THD + Noise vs. Frequency



Figure 25. THD + Noise vs. Output Amplitude (V rms)

The output of the OP176 is designed to maintain low harmonic distortion while driving $600 \Omega$ loads. However, driving $600 \Omega$ loads with very high output swings results in higher distortion if clipping occurs.
To attain low harmonic distortion with large output swings, supply voltages may be increased. Figure 26 shows the performance of the OP176 driving $600 \Omega$ loads with supply voltages varying from $\pm 18$ volts to $\pm 20$ volts. Notice that with $\pm 18$ volt supplies the distortion is fairly high, while with $\pm 20$ volt supplies it is a very low $0.0007 \%$.


Figure 26. THD + Noise vs. Supply Voltage

Figure 24. THD + Noise vs. $R_{\text {LOAD }}$

## Noise

The voltage noise density of the OP 176 is below $6 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ from 30 Hz . This enables low noise designs to have good performance throughout the full audio range. Figure 27 shows a typical OP176 with a $1 / \mathrm{f}$ corner at 6 Hz .


Figure 27. 1/f Noise Corner

## Noise Testing

For audio applications the noise density is usually the most important noise parameter. For characterization the OP176 is tested using an Audio Precision, System One. The input signal to the Audio Precision must be amplified enough to measure accurately. For the OP176 the noise is gained by approximately 1020 using the circuit shown in Figure 28. Any readings on the Audio Precision must then be divided by the gain. In implementing this test fixture, good supply bypassing is essential.


Figure 28. Noise Test

## Upgrading "5534" Sockets

The OP176 is a superior amplifier for upgrading existing designs using the industry standard 5534. In most application circuits, the OP176 can directly replace the 5534 without any modifications to the surrounding circuitry. Like the 5534, the OP176 follows the industry standard, single op amp pinout. The difference between these two devices is the location of the null pins and the 5534's compensation capacitor.
The 5534 normally requires a 22 pF capacitor between Pins 5 and 8 for stable operation. Since the OP176 is internally compensated for unity gain operation, it does not require external compensation. Nevertheless, if the 5534 socket already includes a capacitor, the OP176 can be inserted without removing it. Since the OP176's Pin 8 is a "NO CONNECT" pin , there is no internal connection to that pin. Thus, the 22 pF capacitor would be electrically connected through Pin 5 to the internal nulling circuitry. With the other end left open, the capacitor should have no effect on the circuit. However, to avoid altogether any possibility for noise injection, it is recommended that the 22 pF capacitor be cut out of the circuit entirely.

If the original 5534 socket includes offset nulling circuitry, one would find a $10 \mathrm{k} \Omega$ to $100 \mathrm{k} \Omega$ potentiometer connected between Pins 1 and 8 with said potentiometer's wiper arm connected to $\mathrm{V}+$. In order to upgrade the socket to the OP176, this circuit should be removed before inserting the OP176 for its offset nulling scheme uses Pins 1 and 5 . Whereas the wiper arm of the 5534 trimming potentiometer is connected to the positive supply, the OP176's wiper arm is connected to the negative supply. Directly substituting the OP176 into the original socket would inject a large current imbalance into its input stage. In this case, the potentiometer should be removed altogether, or, if nulling is still required, the trimming potentiometer should be rewired to match the nulling circuit as illustrated in Figure 29.


Figure 29. Offset Voltage Nulling Scheme

## Input Overcurrent Protection

The maximum input differential voltage that can be applied to the OP176 is determined by a pair of internal Zener diodes connected across its inputs. They limit the maximum differential input voltage to $\pm 7.5 \mathrm{~V}$. This is to prevent emitter-base junction breakdown from occurring in the input stage of the OP176 when very large differential voltages are applied.
However, in order to preserve the OP176's low input noise voltage, internal resistances in series with the inputs were not used to limit the current in the clamp diodes. In small signal applications, this is not an issue; however, in applications where large differential voltages can be inadvertently applied to the device, large transient currents can flow through these diodes. Although these diodes have been designed to carry a current of $\pm 5 \mathrm{~mA}$, external resistors as shown in Figure 30 should be used in the event that the OP176's differential voltage were to exceed $\pm 7.5 \mathrm{~V}$.


Figure 30. Input Overcurrent Protection

## Output Voltage Phase Reversal

Since the OP176's input stage combines bipolar transistors for low noise and p-channel JFETs for high speed performance, the output voltage of the OP176 may exhibit phase reversal if either of its inputs exceeds the specified negative common-mode input voltage. This might occur in some applications where a transducer, or a system, fault might apply very large voltages upon the inputs of the OP176. Even though the input voltage range of the OP176 is $\pm 10.5 \mathrm{~V}$, an input voltage of approximately -13.5 V will cause output voltage phase reversal. In inverting amplifier configurations, the OP176's internal 7.5 V clamping diodes will prevent phase reversal; however, they will not prevent this effect from occurring in noninverting applications. For these applications, the fix is a $3.92 \mathrm{k} \Omega$ resistor in series with the noninverting input of the device and is illustrated in Figure 31.


Figure 31. Output Voltage Phase Reversal Fix

## Overdrive Recovery

The overdrive recovery time of an operational amplifier is the time required for the output voltage to recover to a rated output level from a saturated condition. This recovery time is important in applications where the amplifier must recover quickly after a large abnormal transient event. The circuit shown in Figure 32 was used to evaluate the OP176's overload recovery time. The OP176 takes approximately $1 \mu \mathrm{~s}$ to recover to $\mathrm{V}_{\mathrm{OUT}}=$ +10 V and approximately 900 ns to recover to $\mathrm{V}_{\text {out }}=-10 \mathrm{~V}$.


Figure 32. Overload Recovery Time Test Circuit

## High Speed Operation

As with most high speed amplifiers, care should be taken with supply decoupling, lead dress, and component placement. Recommended circuit configurations for inverting and noninverting applications are shown in Figure 33 and Figure 34.


Figure 33. Unity Gain Follower


Figure 34. Unity Gain Inverter
In inverting and noninverting applications, the feedback resistance forms a pole with the source resistance and capacitance ( $\mathrm{R}_{\mathrm{S}}$ and $\mathrm{C}_{\mathrm{S}}$ ) and the OP176's input capacitance ( $\mathrm{C}_{\mathrm{IN}}$ ), as shown in Figure 35. With $R_{s}$ and $R_{F}$ in the $k \Omega$ range, this pole can create excess phase shift and even oscillation. A small capacitor, $\mathrm{C}_{\mathrm{FB}}$, in parallel with $\mathrm{R}_{\mathrm{FB}}$ eliminates this problem. By setting $R_{S}\left(C_{S}+C_{I N}\right)=R_{F B} C_{F B}$, the effect of the feedback pole is completely removed.


Figure 35. Compensating the Feedback Pole

## Attention to Source Impedances Minimizes Distortion

 Since the OP176 is a very low distortion amplifier, careful attention should be given to source impedances seen by both inputs. As with many FET-type amplifiers, the p-channel JFETs in the OP176's input stage exhibit a gate-to-source capacitance that varies with the applied input voltage. In an inverting configuration, the inverting input is held at a virtual ground and, as such, does not vary with input voltage. Thus, since the gate-to-source voltage is constant, there is no distortion due to input capacitance modulation. In noninverting applications, however, the gate-to-source voltage is not constant. The resulting capacitance modulation can cause distortion above 1 kHz if the input impedance is $>2 \mathrm{k} \Omega$ and unbalanced.Figure 36 shows some guidelines for maximizing the distortion performance of the OP176 in noninverting applications. The best way to prevent unwanted distortion is to ensure that the parallel combination of the feedback and gain setting resistors ( $\mathrm{R}_{\mathrm{F}}$ and $\mathrm{R}_{\mathrm{G}}$ ) is less than $2 \mathrm{k} \Omega$. Keeping the values of these resistors small has the added benefits of reducing the thermal noise of the circuit and dc offset errors. If the parallel combination of $\mathrm{R}_{\mathrm{F}}$ and $\mathrm{R}_{\mathrm{G}}$ is larger than $2 \mathrm{k} \Omega$, then an additional resistor, $R_{s}$, should be used in series with the noninverting


Figure 36. Balanced Input Impedance to Mininize Distortion in Noninverting Amplifier Circuits
input. The value of $R_{S}$ is determined by the parallel combination of $\mathrm{R}_{\mathrm{F}}$ and $\mathrm{R}_{\mathrm{G}}$ to maintain the low distortion performance of the OP176. For a more generalized treatment on circuit impedances and their effects on circuit distortion, please review the section on Active Filters at the end of the Applications section.

## Driving Capacitive Loads

As with any high speed amplifier, care must be taken when driving capacitive loads. The graph in Figure 14 shows the OP176's overshoot versus capacitive load. The test circuit is a standard noninverting voltage follower; it is this configuration that places the most demand on an amplifier's stability. For capacitive loads greater than 400 pF , overshoot exceeds $40 \%$ and is roughly equivalent to a $45^{\circ}$ phase margin. If the application requires the OP176 to drive loads larger than 400 pF , then external compensation should be used.
Figure 37 shows a simple circuit which uses an in-the-loop compensation technique that allows the OP176 to drive any capacitive load. The equations in the figure allow optimization of the output resistor, $\mathrm{R}_{\mathrm{X}}$, and the feedback capacitor, $\mathrm{C}_{\mathrm{F}}$, for optimal circuit stability. One important note is that the circuit bandwidth is reduced by the feedback capacitor, $\mathrm{C}_{\mathrm{F}}$, and is given by:

$$
B W=\frac{1}{2 \pi R_{F} C_{F}}
$$



Figure 37. In-the-Loop Compensation Technique for Driving Capacitive Loads

## APPLICATIONS USING THE OP176

## A High Speed, Low Noise Differential Line Driver

The circuit of Figure 38 is a unique line driver widely used in many applications. With $\pm 18 \mathrm{~V}$ supplies, this line driver can deliver a differential signal of 30 V p-p into a $2.5 \mathrm{k} \Omega$ load. The high slew rate and wide bandwidth of the OP176 combine to yield a full power bandwidth of 130 kHz while the low noise front end produces a referred-to-input noise voltage spectral density of $15 \mathrm{nV} / \sqrt{\mathrm{Hz}}$. The circuit is capable of driving lower impedance loads as well. For example, with a reduced output level of 5 V rms ( 14 V p-p), the circuit exhibits a full-power bandwidth of 190 kHz while driving a differential load of $249 \Omega$ ! The design is a transformerless, balanced transmission system where output common-mode rejection of noise is of paramount importance. Like the transformer-based design, either output can be shorted to ground for unbalanced line driver applications without changing the circuit gain of 1 . Other circuit gains can be set according to the equation in the diagram. This allows the design to be easily set for noninverting, inverting, or differential operation.


Figure 38. A High Speed, Low Noise Differential Line Driver

## OP176

## A Low Noise Microphone Preamplifier with a Phantom Power Option

Figure 39 is an example of a circuit that combines the strengths of the SSM2017 and the OP176 into a variable gain microphone preamplifier with an optional phantom power feature. The SSM2017's strengths lie in its low noise and distortion, and gain flexibility/simplicity. However, rated only for $2 \mathrm{k} \Omega$ or higher loads, this makes driving $600 \Omega$ loads somewhat limited with the SSM2017 alone. A pair of OP176s are used in the circuit as a high current output buffer (U2) and a DC servo stage (U3). The OP176's high output current drive capability provides a high level drive into $600 \Omega$ loads when operating from $\pm 18 \mathrm{~V}$ supplies. For a complete treatment of the circuit design details, the interested reader should consult application note AN-242, available from Analog Devices.

This amplifier's performance is quite good over programmed gain ranges of 2 to 2000 . For a typical audio load of $600 \Omega$, THD +N at various gains and an output level of 10 V rms is illustrated in Figure 40. For all but the very highest gain, the THD +N is consistent and well below $0.01 \%$, while the gain of 2000 becomes more limited by noise. The noise performance of the circuit is exceptional with a referred-to-input noise voltage spectral density of $1 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ at a circuit gain of 1000 .


Figure 40. Low Noise Microphone Preamplifier THD + N Performance at Various Gains ( $V_{\text {out }}=10 \mathrm{~V}$ rms and $R_{L}=600 \Omega$ )


Figure 39. A Low Noise Microphone Preamplifier

## A Low Noise, +5 V/+10 V Reference

In many high resolution applications, voltage reference noise can be a major contributor to overall system error. Monolithic voltage references often exhibit too much wide band noise to be used alone in these systems. Only through careful filtering and buffering of these monolithic references can one realize wideband microvolt noise levels. The circuit illustrated in Figure 41 is an example of a low noise precision reference optimized for both ac and dc performance around the OP176. With a +10 V reference (the AD587), the circuit exhibits a 1 kHz spot output noise spectral density $<10 \mathrm{nV} / \sqrt{\mathrm{Hz}}$. The reference output voltage is selectable between 5 V and 10 V , depending only on the selection of the monolithic reference. The output table illustrated in the figure provides a selection of monolithic references compatible with this circuit.


Figure 41. A Low Noise, $+5 \mathrm{~V} /+10 \mathrm{~V}$ Reference

In operation, the basic reference voltage is set by U1, either a 5 V or 10 V 3-terminal reference chosen from the table. In this case, the reference used is a 10 V buried Zener reference, but all U1 IC types shown can plug into the pinout and can be optionally trimmed. The stable 10 V from the reference is then applied to the R1-C1-C2 noise filter, which uses electrolytic capacitors for a low corner frequency. When electrolytic capacitors are used for filtering, one must be cognizant of their dc leakage current errors. Here, however, a dc bootstrap of Cl is used, so this capacitor sees only the small R2 dc drop as bias, effectively lowering its leakage current to negligible levels. The resulting low noise, dc-accurate output of the filter is then buffered by a low noise, unity gain op amp using an OP176. With the OP176's low $\mathrm{V}_{\text {os }}$ and control of the source resistances, the dc performance of this circuit is quite good and will not compromise voltage reference accuracy and/or drift. Also, the OP176 has a typical current limit of 50 mA , so it can provide higher output currents when compared to a typical IC reference alone.

## A Differential ADC Driver

High performance audio sigma-delta ADCs, such as the stereo 16 -bit AD1878 and the 18 -bit AD1879, present challenging design problems with regards to input interfacing. Because of an internal switched capacitor input circuit, the ADC input structure presents a difficult dynamic load to the drive amplifier with fast transient input currents due to their 3 MHz ADC sampling rate. Also, these ADCs inputs are differential with a rated full-scale range of $\pm 6.3 \mathrm{~V}$, or about 4.4 V rms . Hence, the ADC interface circuit of Figure 42 is designed to accept a balanced input signal to drive the low dynamic impedances seen at the inputs of these ADCs. The circuit uses two OP176


Figure 42. A Balanced Driver Circuit for Sigma-Delta ADCs
amplifiers as inverting low-pass filters for their speed and high output current drive. The outputs of the OP176s then drive the differential ADC inputs through an RC network. This RC network buffers the amplifiers against step changes at the ADC sampling inputs using one differential (C3) and two commonmode connected capacitors (C4 and C5). The $51 \Omega$ series resistors isolate the OP176s from the heavily capacitive loads, while the capacitors absorb the transient currents. Operating on $\pm 12 \mathrm{~V}$ supplies, this circuit exhibits a very low THD +N of $0.001 \%$ at 5 V rms outputs. For single-ended drive sources, a third op amp unity gain inverter can be added between R2's ( + ) input terminal and R4. For best results, short-lead, noninductive capacitors are suggested for $\mathrm{C} 3, \mathrm{C} 4$, and C 5 (which are placed close to the ADC), and $1 \%$ metal-film types for R1 through R6. For surface mount PCBs, these components can be NPO ceramic chip capacitors and thin-film chip resistors.

## An RIAA Phono Preamp

Figure 43 illustrates a simple phono preamplifier using RIAA equalization. The OP176 is used here to provide gain and is chosen for its low input voltage noise and high speed performance. The feedback equalization network (R1, R2, C1, and C 2 ) forms a three time constant network, providing reasonably accurate equalization with standard component values. The input components terminate a moving magnet phono cartridge as recommended by the manufacturer, the element values shown being typical. When this ac coupled circuit is built with a low noise bipolar input device such as the OP176, amplifier bias current makes direct cartridge coupling difficult. This circuit uses input and output capacitor coupling to minimize biasing interactions.
Input ac coupling to the amplifier is provided via $C 5$, and the low frequency termination resistance, $R_{T}$, is the parallel equivalent of R6 and R7. R3 of the feedback network is ac grounded via C4, a large value electrolytic. Additionally, this resistor is set to a low value to minimize circuit noise from nonamplifier sources. These design measures reduce the dc offset at the output of the OP176 to a few millivolts. The output coupling network of C3 and R4 is shown as suitable for wide band response, but it can be set to a $7950 \mu \mathrm{~s}$ time constant for use as a 20 Hz rumble filter.
The 1 kHz gain (" $G$ ") of this circuit, controlled by R3, is calculated as:

$$
G(@ 1 \mathrm{kHz})=0.101 \times\left(1+\frac{R 1}{R 3}\right)
$$

For an R3 of $200 \Omega$, the circuit gain is just under $50 \times(\approx 34 \mathrm{~dB})$, and higher gains are possible by decreasing R3. For any value of R3, the R5-C6 time constant should be equal to R3 and the series equivalent of C 1 and C 2 .
Using readily available standard values for network elements ( $\mathrm{R} 1, \mathrm{R} 2, \mathrm{C} 1$, and C 2 ) makes the design easily reproducible and inexpensive. These components are ideally high quality precision types, for low equalization errors and minimum
parasitics. One percent metal-film resistors and two percent film capacitors of polystyrene or polypropylene are recommended. Using the suggested values, the frequency response relative to the ideal RIAA characteristic is within $\pm 0.2 \mathrm{~dB}$ over $20 \mathrm{~Hz}-20 \mathrm{kHz}$. Even tighter response can be achieved by using the alternate values, shown in brackets "[ ]," with the trade-off of a non off-the-shelf part.
As previously mentioned, the OP176 was chosen for three reasons: (1) For optimal circuit noise performance, the amplifier used should exhibit voltage and current noise densities of $5 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ and $1 \mathrm{pA} / \sqrt{\mathrm{Hz}}$, respectively. (2) For high gain accuracy, especially at high stage gains, the amplifier should exhibit a gain bandwidth product in excess of 5 MHz . (3) Equally important because of the $100 \%$ feedback through the network at high frequencies, the amplifier must be unity gain stable. With the OP176, the circuit exhibits low distortion over the entire range, generally well below $0.01 \%$ at outputs levels of 5 V rms using $\pm 18 \mathrm{~V}$ supplies. To achieve maximum performance from this high gain, low level circuit, power supplies should be well regulated and noise free, and care should be taken with shielding and conductor layout.

## Active Filter Circuits Using the OP176

A general active filter topology that lends itself to both high-pass (HP) and low-pass (LP) filters is the well known Sallen-Key (SK) VCVS (Voltage-Controlled, Voltage Source) architecture. This filter type uses the op amp as a fixed gain voltage follower at either unity or a higher gain. Discussed here are simplified 2pole, unity gain forms of these filters, which are attractive for several reasons: One, at audio frequencies, using an amplifier with a 10 MHz bandwidth such as the OP176, these filters exhibit reasonably low sensitivities for unity gain and high damping (low Q). Second, as voltage followers, they are also inherently gain accurate within their pass band; hence, no gain resistor scaling errors are generated. Third, they can also be made "dc accurate," with output dc errors of only a few millivolts. The specific filter response in terms of HP, LP and damping is determined by the RC network around the op amp, as shown in Figure 44a.


Figure 43. An RIAA Phono Preamplifier Circuit

## High Pass Sections

Figure 44a illustrates the high-pass form of a 2-pole SK filter using an OP176. For simplicity and practicality, capacitors C1 and C 2 are set equal ("C"), and resistors R2 and R1 are adjusted to a ratio, N , which provides the filter damping coefficient, $\alpha$, as per the design expressions. This high pass design is begun with selection of standard capacitor values for C 1 and C 2 and a calculation of N . The values for R1 and R2 are then determined from the following expressions:

$$
R I=\frac{I}{2 \pi \times F R E Q \times C \times \sqrt{\mathrm{N}}}
$$

and

$$
R 2=N \times R I
$$



Figures 44a. Two-Pole Unity Gain HP/LP Active Filters
In this examples, circuit $\alpha$ (or $1 / \mathrm{Q}$ ) is set equal to $\sqrt{2}$, providing a Butterworth (maximally flat) characteristic. The filter corner frequency is normalized to 1 kHz , with resistor values shown in both rounded and (exact) form. Various other 2-pole response shapes are possible with appropriate selection of $\alpha$, and frequency can be easily scaled, using inversely proportional R or C values for a given $\alpha$. The $22 \mathrm{~V} / \mu \mathrm{s}$ slew rate of the OP176 will support 20 V p-p outputs above 100 kHz with low distortion. The frequency response resulting with this filter is shown as the dotted HP portion of Figure 45.

## Low Pass Sections

In the LP SK arrangement of Figure 44b, the R and C elements are interchanged where the resistors are made equal. Here, the ratio of $\mathrm{C} 2 / \mathrm{C} 1$ (" M ") is used to set the filter $\alpha$, as noted.
Otherwise, this filter is similar to the HP section, and the resulting 1 kHz LP response is shown in Figure 45. The design begins with a choice of a standard capacitor value for Cl and a calculation of M . This then forces a value of " $\mathrm{M} \times \mathrm{C} 1$ " for C 2 . Then, the value for R1 and R2 (" $R$ ") is calculated according to the following equation:

$$
R=\frac{I}{2 \pi \times F R E Q \times C I \times \sqrt{\mathrm{M}}}
$$



Figures 44b. Two-Pole Unity Gain HP/LP Active Filters


Figure 45. Relative Frequency Response of 2-Pole, 1 kHz Butterworth LP (Left) and HP (Right) Active Filters

## Passive Component Selection for Active Filters

The passive components suitable for active filters deserve more than casual attention. Resistors should be $1 \%$, low TC, metalfilm types of the RN55 or RN60 style. Capacitors should be $1 \%$ or $2 \%$ film types preferably, such as polypropylene or polystyrene, or NPO (COG) ceramic for smaller values.

## Active Filter Circuit Subtleties

In designing active filter circuits with the OP176, moderately low values ( $10 \mathrm{k} \Omega$ or less) for R1 and R2 can be used to minimize the effects of Johnson noise when critical. The practical tradeoff is, of course, capacitor size and expense. DC errors will result for larger values of resistance, unless compensation for amplifier input bias current is used. To add bias compensation in the HP filter section of Figure 42a, a feedback compensation resistor equal to R 2 can be used. This will minimize bias current induced offset to the product of the OP176's $I_{\text {Os }}$ and R2. For an R2 of $25 \mathrm{k} \Omega$, this produces a typical compensated offset voltage of $50 \mu \mathrm{~V}$. Similar compensation is applied to Figure 42b, using a resistance equal to R1+ R2. Using dc compensation, filter output dc errors using the OP176 will be dominated by its $V_{o s}$, which is typically 1 mV or less. A caveat here is that the additional resistors can increase noise substantially. For example, a $10 \mathrm{k} \Omega$ resistor generates $\sim 12 \mathrm{nV} /$ $\sqrt{\mathrm{Hz}}$ of noise and is about twice that of the OP176. These resistors can be ac bypassed to eliminate their noise using a simple shunt capacitor chosen such that its reactance $\left(\mathrm{X}_{\mathrm{C}}\right)$ is much less than R at the lowest frequency of interest.
A more subtle form of ac degradation is also possible in these filters, namely nonlinear input capacitance modulation. This issue was previously covered for general cases in the section on minimizing distortion. In active filter circuits, a fully compensating network (for both dc and ac performance) can be used to minimize this distortion. To be most effective, this network ( $\mathrm{Z}_{\text {сомр }}$ ) should include R 1 through C 2 as noted for either filter type, of the same style and value as their counterparts in the forward path. The effects of a $\mathrm{Z}_{\mathrm{Comp}}$ network on the THD +N performance of two 1 kHz HP filters is illustrated in Figure 46. One filter (A) is the example shown in Figure 44a (Curves A1 and A2), while the second (B) uses RC values scaled 10 times upward in impedance (Curves B1 and B2). Both filters operate with a 2 V rms input, $\pm 18 \mathrm{~V}$ supplies, $100 \mathrm{k} \Omega$ loading, and analyzer bandwidth of 80 kHz .


Figure 46. THD + N(\%) vs. Frequency for Various 1 kHz HP Active Filters Illustrating the Effects of the $Z_{\text {comp }}$ Network
Curves A1 and B1 show performance with $Z_{\text {COMP }}$ shorted, while curves A 2 and B 2 illustrate operation with $\mathrm{Z}_{\mathrm{COMP}}$ active. For the "A" example values, distortion in the pass band of $1 \mathrm{kHz}-20 \mathrm{kHz}$ is below $0.001 \%$ compensated, and slightly higher uncompensated. With the higher impedance " $B$ " network, there is a much greater difference between compensated and uncompensated responses, underscoring the sensitivity to higher impedances. Although the positive effect of $Z_{\text {COMP }}$ is seen for both "A" and "B" cases, there is a buffering effect which takes place with lower impedances. As case " $A$ " shows, when using larger capacitance values in the source, the amplifier's nonlinear $\mathrm{C}-\mathrm{V}$ input characteristics have less effect on the signal.
Thus, to minimize the necessity for the complete $\mathrm{Z}_{\mathrm{COMP}}$ compensation, effective filter designs should use the lowest capacitive impedances practical, with an $0.01 \mu \mathrm{~F}$ lower value limit as a goal for lowest distortion (while lower values can certainly be used, they may suffer higher distortion without the use of full compensation). Since most designs are likely to use low relative impedances for reasons of low noise and offset, the effects of CM distortion may or may not actually be apparent to a given application.



Figure 47. OP176 Spice Model Schematic
OP176 SPICE Model

* Node Assignments

* INPUT STAGE \& POLE AT 100 MHz

| R3 | 5 | 51 | 2.487 |  |
| :--- | :--- | :--- | :--- | :--- |
| R4 | 6 | 51 | 2.487 |  |
| CIN | 1 | 2 | $3.7 \mathrm{E}-12$ |  |
| CM1 | 1 | 98 | $7.5 \mathrm{E}-12$ |  |
| CM2 | 2 | 98 | $7.5 \mathrm{E}-12$ |  |
| C2 | 5 | 6 | $320 \mathrm{E}-12$ |  |
| I1 | 97 | 4 | $100 \mathrm{E}-3$ |  |
| IOS | 1 | 2 | $1 \mathrm{E}-9$ |  |
| EOS | 9 | 3 | POLY(1) | $(26,28)$ |
| Q1 | 5 | 2 | 7 | QX |
| Q2 | 6 | 9 | 8 |  |
| R5 | 7 | 4 | 1.970 |  |
| R6 | 8 | 4 | 1.970 |  |
| D1 | 2 | 36 | DZ |  |
| D2 | 1 | 36 | DZ |  |
| EN | 3 | 1 | $(10,0)$ | 1 |
| GN1 | 0 | 2 | $(13,0)$ | $1 \mathrm{E}-3$ |
| GN2 | 0 | 1 | $(16,0)$ | $1 \mathrm{E}-3$ |
| $\star$ |  |  |  |  |
| EREF98 | 0 | $(28,0)$ | 1 |  |
| EP | 97 | 0 | $(99,0)$ | 1 |
| EM | 51 | 0 | $(50,0)$ | 1 |

* VOLTAGE NOISE SOURCE

| DN1 | 35 | 10 | DEN |
| :--- | :--- | :--- | :--- |
| DN2 | 10 | 11 | DEN |
| VN1 35 | 0 | DC 2 |  |
| VN2 | 0 | 11 | DC 2 |

* 
* CURRENT NOISE SOURCE

| DN3 | 12 | 13 | DIN |
| :---: | :---: | :---: | :---: |
| DN4 | 13 | 14 | DIN |
| VN3 | 12 | 0 | DC 2 |
| VN4 | 0 | 14 | DC 2 |
| * CURRENT NOISE SOURCE |  |  |  |
| DN5 | 15 | 16 | DIN |
| DN6 | 16 | 17 | DIN |
| VN5 | 15 | 0 | DC 2 |
| VN6 | 0 | 17 | DC 2 |
| * |  |  |  |
| * GAIN STAGE \& DOMINANT <br> * |  |  |  |
| R7 | 18 | 98 | 1.243 |
| C3 | 18 | 98 | 4E-9 |
| G1 | 98 | 18 | $(5,6)$ |
| V2 | 97 | 19 | 1.35 |
| V3 | 20 | 51 | 1.35 |
| D3 | 18 | 19 | DX |
| D4 | 2018 DX |  |  |

* POLE/ZERO PAIR AT $1.5 \mathrm{MHz} / 2.7 \mathrm{MHz}$

| R8 | 21 | 98 | 1 E 3 |  |
| :--- | :--- | :--- | :--- | :--- |
| R9 | 21 | 22 | 1.25 E 3 |  |
| C4 | 22 | 98 | $47.2 \mathrm{E}-12$ |  |
| G2 | 98 | 21 | $(18,28)$ | 1 E |
| $\star$ |  |  |  |  |
| $\star$ |  |  |  |  |
| $\star$ |  |  |  |  |
| $\star$ |  |  |  |  |
| R10 | 23 | 98 | 1 |  |
| C5 | 23 | 98 | $1.59 \mathrm{E}-9$ |  |
| G3 | 98 | 23 | $(21,28)$ | 1 |

* POLE AT 100 MHz
* 

$\begin{array}{llll}\text { R11 } & 24 & 98 & 1\end{array}$

| C6 | 24 | 98 | $1.59 \mathrm{E}-9$ |  |
| :--- | :--- | :--- | :--- | :--- |
| G4 | 98 | 24 | $(23,28)$ | 1 |

* 
* COMMON-MODE GAIN NETWORK WITH ZERO AT 1 kHz
$\begin{array}{llll}\text { R12 } & 25 & 26 & \text { 1E6 }\end{array}$

| R12 | 25 | 26 | 1E6 |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| C7 | 25 | 26 | $60 \mathrm{E}-12$ |  |  |  |
| R13 | 26 | 98 | 1 |  |  |  |
| E2 | 25 | 98 | POLY(2) | $(1,98)$ | $(2,98)$ | 02.502 .50 |

* POLE AT 100 MHz
* 

| R 14 | 27 | 98 | 1 |  |
| :--- | :--- | :--- | :--- | :--- |
| C8 | 27 | 98 | $1.59 \mathrm{E}-9$ |  |
| G5 | 98 | 27 | $(24,28)$ | 1 |

* OUTPUT STAGE
* 



## OP177

## FEATURES

- Ultra-Low Offset Voltage
$\qquad$
$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$
$10 \mu \mathrm{~V}$ Max
$-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq 125^{\circ} \mathrm{C}$ $20 \mu \mathrm{~V}$ Max
- Outstanding Offset Voltage Drift $0.1 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ Max
- Excellent Open-Loop Gain and Gain Linearity
$12 \mathrm{~V} / \mu \mathrm{V}$ Typ
- CMRR 130dB Min
- PSRR 120dB Min
- Low Supply Current 2.0 mA Max
- Fits Industry Standard Precision Op Amp Sockets (OP07/OP77)


## ORDERING INFORMATION ${ }^{\dagger}$

| PACKAGE |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
| CERDIP | PLASTIC | LCC | SO | OPERATING <br> TEMPERATURE |
| 8-PIN | 8-PIN | 20-PIN | 8-PIN | RANGE |
| OP177AZ* $^{\text {O-PIN }}$ | - | - | - | MIL |
| OP177BZ* | - | OP177BRC/883 | - | MIL |
| OP177EZ | - | - | - | XIND |
| OP177FZ | OP177FP | - | - | XIND |
| OP177GZ | OP177GP | - | OP177GS | XIND |

MIL $=-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C} \quad$ XIND $=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$

- For devices processed in total compliance to MIL-STD-883, add /883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in cerDIP, plastic DIP, and TO-can packages.


## GENERAL DESCRIPTION

The OP-177 features the highest precision performance of any op amp currently available. Offset voltage of the OP-177 is only $10 \mu \mathrm{~V}$ MAX at room temperature and $20 \mu \mathrm{~V}$ MAX over the full military temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. The ultra-low $\mathrm{V}_{\mathrm{OS}}$ of the OP-177, combines with its exceptional offset voltage

PIN CONNECTIONS


> EPOXY MINI-DIP (P-Suffix)

8-PIN HERMETIC DIP (Z-Suffix)

8-PIN SO
(S-Suffix)


OP-177BRC/883
LCC
(RC-Suffix)
drift ( $\mathrm{TCV}_{\mathrm{OS}}$ ) of $0.1 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ MAX, to eliminate the need for external $\mathrm{V}_{\text {os }}$ adjustment and increases system accuracy over tem-

The OP-177's open-loop gain of $12 \mathrm{~V} / \mu \mathrm{V}$ is maintained over the full $\pm 10 \mathrm{~V}$ output range. CMRR of 130 dB MIN, PSRR of 120 dB MIN, and maximum supply current of 2 mA are just a few examples of the excellent performance of this operational amplifier. The OP-177's combination of outstanding specifications insure accurate performance in high closed-loop gain applications.

This low noise bipolar input op amp is also a cost effective alternative to chopper-stabilized amplifiers. The OP-177 provides chopper-type performance without the usual problems of high noise, low frequency chopper spikes, large physical size, limited common-mode input voltage range, and bulky external storage capacitors.

Continued


This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

## OP171

## GENERAL DESCRIPTION Continued

The OP-177 is offered in both the $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ military, and the $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ extended industrial temperature ranges. This product is available in 8 -pin ceramic and epoxy DIPs, as well as the space saving 8-pin Small-Outline (SO) and the Leadless Chip Carrier (LCC) packages.

## ABSOLUTE MAXIMUM RATINGS

Supply Voltage ..... $\pm 22 \mathrm{~V}$
Differential Input Voltage ..... $\pm 30 \mathrm{~V}$
Input Voltage (Note 1) ..... $\pm 22 \mathrm{~V}$
Output Short-Circuit Duration ..... Indefinite
Storage Temperature Range
$Z$ and RC Packages ..... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
P Package ..... $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$

Operating Temperature Range

| OP-177A, OP-177B ............................... $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  |  |  |
| :---: | :---: | :---: | :---: |
| OP-177E, OP-177F, OP-177G .................. $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  |  |
| Lead Temperature Range (Soldering, 60 sec ) .............. $300^{\circ} \mathrm{C}$ Junction Temperature ( $\mathrm{T}_{\mathrm{i}}$ ) ........................... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |  |  |  |
|  |  |  |  |
| PACKAGE TYPE | $\theta_{\text {IA }}$ (NOTE 2) | $\theta_{\text {Ic }}$ | UNITS |
| 8-Pin Hermetic DIP (Z) | 148 | 16 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8 -Pin Plastic DIP (P). | 103 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 20-Contact LCC (RC) | 98 | 38 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8 -Pin SO (S) | 158 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTES:

1. For supply voltages less than $\pm 22 \mathrm{~V}$, the absolute maximum input voltage is equal to the supply voltage.
2. $\boldsymbol{\Theta}_{j A}$ is specified for worst case mounting conditions, i.e., $\boldsymbol{\theta}_{\mathrm{jA}}$ is specified for device in socket for CerDIP, P-DIP, and LCC packages; $\boldsymbol{\theta}_{j A}$ is specified for device soldered to printed circuit board for SO package.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{S}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.


## NOTES:

1. Long-Term Input Offset Voltage Stability refers to the averaged trend line of $\mathrm{V}_{\mathrm{OS}} \mathrm{vs}$. Time over extended periods after the first 30 days of operation. Excluding the initial hour of operation, changes in $\mathrm{V}_{\mathrm{Os}}$ during the first 30 operating days are typically less than $2.0 \mu \mathrm{~V}$.
2. Sample tested.
3. Guaranteed by design.
4. Guaranteed by CMRR test condition.
5. To insure high open-loop gain throughout the $\pm 10 \mathrm{~V}$ output range, $\mathrm{A}_{\mathrm{Vo}}$ is tested at $-10 \mathrm{~V} \leq \mathrm{V}_{\mathrm{O}} \leq 0 \mathrm{~V}, 0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{O}} \leq+10 \mathrm{~V}$, and $-10 \mathrm{~V} \leq \mathrm{V}_{\mathrm{O}} \leq+10 \mathrm{~V}$.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{S}= \pm 15 \mathrm{~V},-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-177A |  |  | OP-177B |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input Offset Voltage | $\mathrm{V}_{\text {OS }}$ |  | - | 10 | 20 | - | 25 | 55 | $\mu \mathrm{V}$ |
| Average Input Offset Voltage Drift | $\mathrm{TCV}_{\text {OS }}$ | (Note 1) | - | 0.03 | 0.1 | - | 0.1 | 0.3 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current | ${ }^{\text {I OS }}$ |  | - | 0.5 | 1.5 | - | 0.5 | 2.0 | nA |
| Average Input Offset Current Drift | $\mathrm{TCl}_{\mathrm{OS}}$ | (Note 2) | - | 1.5 | 25 | - | 1.5 | 25 | $\mathrm{pA} /{ }^{\circ} \mathrm{C}$ |
| Input Bias Current | ${ }^{\text {B }}$ |  | -0.2 | 2.4 | 4 | -0.2 | 2.4 | 4 | $n \mathrm{~A}$ |
| Average Input Bias Current Drift | $\mathrm{TCl}_{\mathrm{B}}$ | (Note 2) | - | 8 | 25 | - | 8 | 25 | $\mathrm{pA} /{ }^{\circ} \mathrm{C}$ |
| Input Voltage Range | IVR | (Note 3) | $\pm 13$ | $\pm 13.5$ | - | $\pm 13$ | $\pm 13.5$ | - | V |
| Common-Mode Rejection Ratio | CMRR | $\mathrm{V}_{\mathrm{CM}}= \pm 13 \mathrm{~V}$ | 120 | 140 | - | 120 | 140 | - | dB |
| Power Supply Rejection Ratio | PSRR | $\mathrm{V}_{S}= \pm 3 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | 120 | 125 | - | 110 | 120 | - | dB |
| Large-Signal Voltage Gain | ${ }^{\text {AVO }}$ | $R_{L} \geq 2 \mathrm{k} \Omega, \mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V}$ (Note 4) | 2000 | 6000 | - | 2000 | 6000 | - | $\mathrm{V} / \mathrm{mV}$ |
| Output Voltage Swing | $\mathrm{V}_{\mathrm{O}}$ | $R_{L} \geq 2 \mathrm{k} \Omega$ | $\pm 12$ | $\pm 13.0$ | - | $\pm 12$ | $\pm 13.0$ | - | V |
| Power Consumption | $\mathrm{P}_{\mathrm{d}}$ | $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}$, No Load | - | 60 | 75 | - | 60 | 75 | mW |
| Supply Current | ${ }_{\text {I }}^{\text {SY }}$ | $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}$, No Load | - | 2.0 | 2.5 | - | 2.0 | 2.5 | mA |

## NOTES:

1. $\mathrm{TCV}_{\mathrm{OS}}$ is $100 \%$ tested.
2. Guaranteed by end-point limits.
3. Guaranteed by CMRR test condition.
4. To insure high open-loop gain throughout the $\pm 10 \mathrm{~V}$ output range, $\mathrm{A}_{\mathrm{Vo}}$ is tested at $-10 \mathrm{~V} \leq \mathrm{V}_{\mathrm{O}} \leq 0 \mathrm{~V}, 0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{O}} \leq+10 \mathrm{~V}$, and $-10 \mathrm{~V} \leq \mathrm{V}_{\mathrm{O}} \leq+10 \mathrm{~V}$.

BURN-IN CIRCUIT


## OPTIONAL OFFSET NULLING CIRCUIT



ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-177E |  |  | OP-177F |  |  | OP-177G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Input Offset Voltage | $\mathrm{v}_{\text {os }}$ |  | - | 4 | 10 | - | 10 | 25 | - | 20 | 60 | $\mu \mathrm{V}$ |
| Long-Term $\mathrm{V}_{\mathrm{OS}}$ Stability | $\mathrm{V}_{\text {os }}$ /Time | (Note 1) | - | 0.2 | - | - | 0.3 | - | - | 0.4 | - | $\mu \mathrm{V} / \mathrm{Mo}$ |
| Input Offset Current | $\mathrm{l}_{\mathrm{os}}$ |  | - | 0.3 | 1.0 | - | 0.3 | 1.5 | - | 0.3 | 2.8 | nA |
| Input Bias Current | $\mathrm{I}_{B}$ |  | -0.2 | 1.0 | 1.5 | -0.2 | 1.2 | 2.0 | -0.2 | 1.2 | 2.8 | nA |
| Input Noise Voltage | $e_{n}$ | $\mathrm{f}_{0}=1 \mathrm{~Hz}$ to 100 Hz (Note 2) | - | 118 | 150 | - | 118 | 150 | - | 118 | 150 | $n V_{\text {RMS }}$ |
| Input Noise Current | $i_{n}$ | $\mathrm{f}_{0}=1 \mathrm{~Hz}$ to 100 Hz (Note 2) | - | 3 | 8 | - | 3 | 8 | - | 3 | 8 | $\mathrm{pA}_{\text {RMS }}$ |
| Input Resistance -Differential-Mode | $\mathrm{R}_{\text {IN }}$ | (Note 3) | 26 | 45 | - | 26 | 45 | - | 18.5 | 45 | - | M $\Omega$ |
| Input Resistance -Common-Mode | $\mathrm{R}_{\text {INCM }}$ |  | - | 200 | - | - | 200 | - | - | 200 | - | G $\Omega$ |
| Input Voltage Range | IVR | (Note 4) | $\pm 13$ | $\pm 14$ | - | $\pm 13$ | $\pm 14$ | - | $\pm 13$ | $\pm 14$ | - | v |
| Common-Mode Rejection Ratio | CMRR | $V_{C M}= \pm 13 \mathrm{~V}$ | 130 | 140 | - | 130 | 140 | - | 115 | 140 | - | dB |
| Power Supply Rejection Ratio | PSRR | $\mathrm{V}_{\mathrm{S}}= \pm 3 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | 120 | 125 | - | 115 | 125 | - | 110 | 120 | - | dB |
| Large-Signal Voltage Gain | $A_{\text {vo }}$ | $\begin{aligned} & R_{\mathrm{L}} \geq 2 \mathrm{k} \Omega, \\ & \mathrm{~V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \text { (Note } 5 \text { ) } \end{aligned}$ | 5000 | 12000 | - | 5000 | 12000 | - | 2000 | 6000 | - | V/mV |
| Output Voltage Swing | $\mathrm{V}_{0}$ | $\begin{aligned} & R_{L} \geq 10 \mathrm{k} \Omega \\ & R_{L} \geq 2 k \Omega \\ & R_{L} \geq 1 \mathrm{k} \Omega \end{aligned}$ | $\begin{aligned} & \pm 13.5 \\ & \pm 12.5 \\ & \pm 12.0 \end{aligned}$ | $\begin{aligned} & \pm 14.0 \\ & \pm 13.0 \\ & \pm 12.5 \end{aligned}$ | - | $\begin{aligned} & \pm 13.5 \\ & \pm 12.5 \\ & \pm 12.0 \end{aligned}$ | $\begin{aligned} & \pm 14.0 \\ & \pm 13.0 \\ & \pm 12.5 \end{aligned}$ | - | $\pm 13.5$ $\pm 12.5$ $\pm 12.0$ | $\pm 14.0$ $\pm 13.0$ $\pm 12.5$ | - | v |
| Slew Rate | SR | $\mathrm{R}_{\mathrm{L}} \geq 2 \mathrm{k} \Omega$ (Note 2) | 0.1 | 0.3 | - | 0.1 | 0.3 | - | 0.1 | 0.3 | - | V/us |
| Closed-Loop Bandwidth | BW | $\begin{aligned} & \mathrm{A}_{\mathrm{VCL}}=+1 \\ & \text { (Note 2) } \end{aligned}$ | 0.4 | 0.6 | - | 0.4 | 0.6 | - | 0.4 | 0.6 | - | MHz |
| Open-Loop Output Resistance | $\mathrm{R}_{0}$ |  | - | 60 | - | - | 60 | - | - | 60 | - | $\Omega$ |
| Power Consumption | $\mathrm{P}_{\mathrm{d}}$ | $\begin{aligned} & V_{S}= \pm 15 \mathrm{~V}, \text { No Load } \\ & V_{S}= \pm 3 \mathrm{~V}, \text { No Load } \end{aligned}$ | - | 50 3.5 |  | - | 50 3.5 | 60 4.5 | - | 50 3.5 | $\begin{array}{r} 60 \\ 4.5 \end{array}$ | mW |
| Supply Current | $\mathrm{I}_{\text {SY }}$ | $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}$, No Load | - | 1.6 | 2.0 | - | 1.6 | 2.0 | - | 1.6 | 2.0 | mA |
| Offset Adjustment Range |  | $\mathrm{R}_{\mathrm{p}}=20 \mathrm{k} \Omega$ | - | $\pm 3$ | - | - | $\pm 3$ | - | - | $\pm 3$ | - | mV |

## NOTES:

1. Long-Term Input Offset Voltage Stability refers to the averaged trend line of
$\mathrm{V}_{\mathrm{OS}} \mathrm{vs}$. Time over extended periods after the first 30 days of operation. Excluding the initial hour of operation, changes in $\mathrm{V}_{\mathrm{OS}}$ during the first 30 operating days are typically less than $2.0 \mu \mathrm{~V}$.
2. Sample tested.
3. Guaranteed by design.
4. Guaranteed by CMRR test condition.
5. To insure high Open-loop gain throughout the $\pm 10 \mathrm{~V}$ output range, $\mathrm{A}_{\mathrm{V}}$ is tested at $-10 \mathrm{~V} \leq \mathrm{V}_{\mathrm{O}} \leq 0 \mathrm{~V}, 0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{O}} \leq+10 \mathrm{~V}$, and $-10 \mathrm{~V} \leq \mathrm{V}_{\mathrm{O}} \leq+10 \mathrm{~V}$.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{S}= \pm 15 \mathrm{~V},-40^{\circ} \mathrm{C} \leq T_{A} \leq \pm 85^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-177E |  |  | OP-177F |  |  | OP-177G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Input Offset Voltage | $\mathrm{V}_{\mathrm{OS}}$ |  | - | 10 | 20 | - | 15 | 40 | - | 20 | 100 | $\mu \mathrm{V}$ |
| Average Input Offset Voltage Drift | $\mathrm{TCV}_{\text {OS }}$ | (Note 1) | - | 0.03 | 0.1 | - | 0.1 | 0.3 | - | 0.7 | 1.2 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current | Ios |  | - | 0.5 | 1.5 | - | 0.5 | 2.2 | - | 0.5 | 4.5 | nA |
| Average Input Offset Current Drift | $\mathrm{TCl}_{\mathrm{OS}}$ | (Note 2) | - | 1.5 | 25 | - | 1.5 | 40 | - | 1.5 | 85 | $\mathrm{pA} /{ }^{\circ} \mathrm{C}$ |
| Input Bias Current | $I_{B}$ |  | -0.2 | 2.4 | 4.0 | -0.2 | 2.4 | 4.0 | - | 2.4 | $\pm 6.0$ | nA |
| Average Input Bias Current Drift | TCIB | (Note 2) | - | 8 | 25 | - | 8 | 40 | - | 15 | 60 | $\mathrm{pA} /{ }^{\circ} \mathrm{C}$ |
| Input Voltage Range | IVR | (Note 3) | $\pm 13.0$ | $\pm 13.5$ | - | $\pm 13.0$ | $\pm 13.5$ | - | $\pm 13.0$ | $\pm 13.5$ | - | V |
| Common-Mode Rejection Ratio | CMRR | $V_{C M}= \pm 13 \mathrm{~V}$ | 120 | 140 | - | 120 | 140 | - | 110 | 140 | - | dB |
| Power Supply Rejection Ratio | PSRR | $\mathrm{V}_{S}= \pm 3 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | 120 | 125 | - | 110 | 120 | - | 106 | 115 | - | dB |
| Large-Signal Voltage Gain | $A_{\text {vo }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}} \geq 2 \mathrm{k} \Omega \\ & \mathrm{~V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \end{aligned}$ | 2000 | 6000 | - | 2000 | 6000 | - | 1000 | 4000 | - | $\mathrm{V} / \mathrm{mV}$ |
| Output Voltage Swing | $\mathrm{V}_{0}$ | $\mathrm{R}_{\mathrm{L}} \geq 2 \mathrm{k} \Omega$ | $\pm 12.0$ | $\pm 13.0$ | - | $\pm 12.0$ | $\pm 13.0$ | - | $\pm 12.0$ | $\pm 13.0$ | - | V |
| Power Consumption | $P_{d}$ | $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}$, No Load | - | 60 | 75 | - | 60 | 75 | - | 60 | 75 | mW |
| Supply Current | $I_{S Y}$ | $V_{S}= \pm 15 \mathrm{~V}$, No Load | - | 2.0 | 2.5 | - | 2.0 | 2.5 | - | 2.0 | 2.5 | mA |

## NOTES:

1. OP177E and OP177F: TCV $_{\text {OS }}$ is $100 \%$ tested.
2. Guaranteed by end-point limits.
3. Guaranteed by CMRR test condition.
4. To insure high open-loop gain throughout the $\pm 10 \mathrm{~V}$ output range, $\mathrm{A}_{\mathrm{Vo}}$ is tested at $-10 \mathrm{~V} \leq \mathrm{V}_{\mathrm{O}} \leq 0 \mathrm{~V}, 0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{O}} \leq+10 \mathrm{~V}$, and $-10 \mathrm{~V} \leq \mathrm{V}_{\mathrm{O}} \leq+10 \mathrm{~V}$.

## OP183/0P283

FEATURES
Single-Supply - +3 Volts to +36 Volts
Wide Bandwidth - 5 MHz
Low Offset Voltage - <1 mV
High Slew Rate - 10 V/ $\mu \mathrm{s}$
Low Noise - 10 nV/ VHz
Unity-Gain Stable
Input and Output Range Includes GND
No Phase Reversal

## APPLICATIONS

## Multimedia

Telecom
ADC Buffers
Wide Band Filters
Microphone Preamplifiers

## GENERAL DESCRIPTION

The OP183 is a single-supply, 5 MHz bandwidth amplifier with slew rates of $10 \mathrm{~V} / \mu \mathrm{s}$. The OP283 is a dual version. Both can operate from voltages as low as 3 volts and up to 36 volts. This combination of slew rate and bandwidth yields excellent singlesupply ac performance making them ideally suited for telecom and multimedia audio applications.
In addition to its ac characteristics, the OP183 family provides good dc performance with guaranteed 1 mV offset. Noise is a respectable $10 \mathrm{nV} / \sqrt{ } \mathrm{Hz}$. Supply current is only 1.2 mA per amplifier.
These amplifiers are well suited for single-supply applications that require moderate bandwidths even when used in high gain configurations. This makes them useful in filters and instrumentation. Their output drive capability and very wide full power bandwidth make them a good choice for multimedia headphone drivers or microphone input amplifiers.

The OP183 and OP283 are available in 8-pin plastic DIP and SO-8 surface mount packages. They are specified over the extended industrial $\left(-40^{\circ} \mathrm{C}\right.$ to $\left.+85^{\circ} \mathrm{C}\right)$ temperature range.

PIN CONNECTIONS


8-Lead Narrow-Body SO (S Suffix)


8-Lead Epoxy DIP (P Suffix)


8-Lead Epoxy DIP (P Suffix)


SPECIFICATIONS
ELECTRICAL CHARACTERISTICS (© $\mathrm{v}_{\mathrm{s}}=+5.5 . \mathrm{V}, \mathrm{T}_{\mathrm{L}}=75^{\circ} \mathrm{c}$ uness stitemise noteded)

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT CHARACTERISTICS <br> Offset Voltage <br> Input Bias Current <br> Input Offset Current <br> Input Voltage Range <br> Common-Mode Rejection Ratio <br> Large Signal Voltage Gain <br> Offset Voltage Drift <br> Bias Current Drift | $\mathrm{V}_{\mathrm{os}}$ <br> $\mathrm{I}_{\mathrm{B}}$ <br> $\mathrm{I}_{\mathrm{OS}}$ <br> CMRR <br> $\mathrm{A}_{\mathrm{vo}}$ <br> $\Delta V_{o S} / \Delta T$ <br> $\Delta \mathrm{I}_{\mathrm{B}} / \Delta \mathrm{T}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{CM}}=2.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{OUT}}=2.5 \mathrm{~V}, \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{CM}}=2.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{OUT}}=2.5 \mathrm{~V}, \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{CM}}=2.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{OUT}}=2.5 \mathrm{~V}, \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \text { to } 3.5 \mathrm{~V} \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, 0.2 \leq \mathrm{V}_{\mathrm{O}} \leq 3.8 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 0 \\ & 70 \\ & 100 \end{aligned}$ | $\begin{aligned} & 0.025 \\ & 350 \\ & 430 \\ & 11 \\ & \\ & 104 \\ & 4 \\ & -1.6 \end{aligned}$ | $\begin{aligned} & 1.0 \\ & 1.25 \\ & 600 \\ & 750 \\ & \\ & \pm 50 \\ & +3.5 \end{aligned}$ | mV <br> mV <br> nA <br> nA <br> nA <br> nA <br> V <br> dB <br> $\mathrm{V} / \mathrm{mV}$ <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ <br> $\mathrm{nA} /{ }^{\circ} \mathrm{C}$ |
| OUTPUT CHARACTERISTICS <br> Output Voltage High <br> Output Voltage Low <br> Short Circuit Limit | $\mathrm{V}_{\mathrm{OH}}$ <br> $\mathrm{V}_{\mathrm{OL}}$ <br> $\mathrm{I}_{\mathrm{SC}}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \text { to GND } \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \text { to GND } \end{aligned}$ <br> Source <br> Sink | +4.0 | $\begin{aligned} & 4.22 \\ & 50 \\ & 25 \\ & 30 \end{aligned}$ | 75 | V <br> mV <br> mA <br> mA |
| POWER SUPPLY <br> Power Supply Rejection Ratio <br> Supply Current/Amplifier <br> Supply Voltage Range | PSRR <br> $\mathrm{I}_{S Y}$ <br> $\mathrm{V}_{\mathrm{s}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=+4 \mathrm{~V} \text { to }+6 \mathrm{~V}, \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{O}}=2.5 \mathrm{~V}, \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \end{aligned}$ | $70$ $+3$ | $\begin{aligned} & 104 \\ & 1.2 \end{aligned}$ | $\begin{aligned} & 1.5 \\ & \pm 18 \end{aligned}$ | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~mA} \\ & \mathrm{~V} \end{aligned}$ |
| DYNAMIC PERFORMANCE <br> Slew Rate <br> Full-Power Bandwidth <br> Settling Time Gain Bandwidth Product Phase Margin | SR <br> BWp <br> $\mathrm{t}_{\mathrm{s}}$ <br> GBP <br> $\theta 0$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ <br> $1 \%$ Distortion To 0.01\% | 5 | $\begin{aligned} & 10 \\ & >50 \\ & 1.5 \\ & 5 \\ & 46 \end{aligned}$ |  | $\mathrm{V} / \mu \mathrm{s}$ <br> kHz <br> $\mu \mathrm{s}$ <br> MHz <br> Degrees |
| NOISE PERFORMANCE <br> Voltage Noise Voltage Noise Density Current Noise Density | $\begin{aligned} & e_{n p-p} \\ & e_{n} \\ & i_{n} \end{aligned}$ | $\begin{aligned} & 0.1 \mathrm{~Hz} \text { to } 10 \mathrm{~Hz} \\ & \mathrm{f}=1 \mathrm{kHz}, \mathrm{~V}_{\mathrm{CM}}=2.5 \mathrm{~V} \end{aligned}$ |  | $\begin{aligned} & 2 \\ & 10 \\ & 0.4 \end{aligned}$ |  | $\mu \mathrm{V}$ p-p <br> $\mathrm{nV} / \sqrt{ } \mathrm{Hz}$ <br> $\mathrm{pA} / \sqrt{ } \mathrm{Hz}$ |

ELECTRICAL CHARACTERISTICS (@ $\mathrm{V}_{\mathrm{s}}=+3.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT CHARACTERISTICS <br> Offset Voltage <br> Input Bias Current <br> Input Offset Current <br> Input Voltage Range <br> Common-Mode Rejection Ratio <br> Large Signal Voltage Gain | $\mathrm{V}_{\mathrm{os}}$ <br> $\mathrm{I}_{\mathrm{B}}$ <br> $\mathrm{I}_{\mathrm{OS}}$ <br> CMRR <br> $\mathrm{A}_{\mathrm{vo}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{CM}}=1.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{OUT}}=1.5 \mathrm{~V} \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{CM}}=1.5 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=1.5 \mathrm{~V}, \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{CM}}=1.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{OUT}}=1.5 \mathrm{~V} \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V} \text { to } 1.5 \mathrm{~V} \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, 0.2 \leq \mathrm{V}_{\mathrm{O}} \leq 1.8 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 0 \\ & 70 \\ & 100 \end{aligned}$ | 0.3 <br> 350 <br> 11 $\begin{aligned} & 103 \\ & 260 \end{aligned}$ | $\begin{aligned} & 1.0 \\ & 1.25 \\ & 600 \\ & 750 \\ & \\ & \pm 50 \\ & +1.5 \end{aligned}$ | mV <br> mV <br> nA <br> nA <br> nA <br> nA <br> V <br> dB <br> V/mV |
| OUTPUT CHARACTERISTICS <br> Output Voltage High <br> Output Voltage Low <br> Short Circuit Limit | $\mathrm{V}_{\mathrm{OH}}$ <br> $\mathrm{V}_{\text {OL }}$ <br> $\mathrm{I}_{\mathrm{SC}}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \text { to GND } \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \text { to } \mathrm{GND} \end{aligned}$ <br> Source <br> Sink | +2.0 | $\begin{aligned} & 2.25 \\ & 90 \\ & 25 \\ & 30 \end{aligned}$ | 125 | $\begin{aligned} & \mathrm{V} \\ & \mathrm{mV} \\ & \mathrm{~mA} \\ & \mathrm{~mA} \end{aligned}$ |
| POWER SUPPLY <br> Power Supply Rejection Ratio <br> Supply Current/Amplifier | PSRR <br> $\mathrm{I}_{\mathrm{sY}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=+2.5 \mathrm{~V} \text { to }+3.5 \mathrm{~V}, \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}, \mathrm{~V}_{\mathrm{O}}=1.5 \mathrm{~V} \end{aligned}$ | 60 | $\begin{aligned} & 113 \\ & 1.2 \end{aligned}$ | 1.5 | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~mA} \end{aligned}$ |
| DYNAMIC PERFORMANCE Gain Bandwidth Product | GBP |  |  | 5 |  | MHz |
| NOISE PERFORMANCE <br> Voltage Noise Density | $e_{n}$ | $\mathrm{f}=1 \mathrm{kHz}, \mathrm{V}_{\mathrm{CM}}=1.5 \mathrm{~V}$ |  | 10 |  | $\mathrm{nV} / \sqrt{ } \mathrm{Hz}$ |

ELECTRICAL CHARACTERISTICS $\left(\Theta v_{s}= \pm 15.0, V_{1}=+25^{\circ}\right.$ culess otherwise noted)

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT CHARACTERISTICS <br> Offset Voltage <br> Input Bias Current <br> Input Offset Current <br> Input Voltage Range Common-Mode Rejection Ratio <br> Large Signal Voltage Gain Offset Voltage Drift <br> Bias Current Drift Long Term Offset Voltage | $\begin{aligned} & \mathrm{V}_{\mathrm{os}} \\ & \mathrm{I}_{\mathrm{B}} \\ & \mathrm{I}_{\mathrm{os}} \\ & \text { CMRR } \\ & \\ & \mathrm{A}_{\mathrm{vo}} \\ & \Delta \mathrm{~V}_{\mathrm{og}} / \Delta \mathrm{T} \\ & \Delta \mathrm{I}_{\mathrm{B}} / \Delta \mathrm{T} \\ & \mathrm{~V}_{\mathrm{os}} \end{aligned}$ | $\begin{aligned} & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & -40 \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{CM}}=-15 \mathrm{~V} \text { to }+13.5 \mathrm{~V}, \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \end{aligned}$ <br> Note 1 | $\begin{aligned} & -15 \\ & 70 \\ & 100 \end{aligned}$ | $\begin{aligned} & 0.01 \\ & \\ & 300 \\ & 400 \\ & 11 \\ & \\ & 86 \\ & 1000 \\ & 3 \\ & -1.6 \end{aligned}$ | $\begin{aligned} & 1.0 \\ & 1.25 \\ & 600 \\ & 750 \\ & \pm 50 \\ & +13.5 \end{aligned}$ | mV <br> mV <br> nA <br> nA <br> nA <br> V <br> dB <br> $\mathrm{V} / \mathrm{mV}$ <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ <br> $\mathrm{nA} /{ }^{\circ} \mathrm{C}$ <br> mV |
| OUTPUT CHARACTERISTICS Output Voltage High Output Voltage Low Short-Circuit Limit Open -Loop Output Impedance | $\begin{aligned} & \mathrm{V}_{\mathrm{OH}} \\ & \mathrm{~V}_{\mathrm{OL}} \\ & \mathrm{I}_{\mathrm{SC}} \\ & \mathrm{Z}_{\mathrm{OUT}} \end{aligned}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \text { to } \mathrm{GND},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \text { to GND, }-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \end{aligned}$ <br> Source <br> Sink $\mathrm{f}=1 \mathrm{MHz}, \mathrm{~A}_{\mathrm{v}}=+1$ | +13.9 | $\begin{aligned} & 14.1 \\ & -14.05 \\ & 30 \\ & 50 \\ & 15 \end{aligned}$ | -13.9 | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~mA} \\ & \mathrm{~mA} \\ & \Omega \end{aligned}$ |
| POWER SUPPLY <br> Power Supply Rejection Ratio <br> Supply Current/Amplifier <br> Supply Voltage Range | PSRR <br> $\mathrm{I}_{\mathrm{SY}}$ $\mathrm{V}_{\mathrm{s}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}= \pm 2.5 \mathrm{~V} \text { to } \pm 18 \mathrm{~V}, \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 18 \mathrm{~V}, \mathrm{~V}_{\mathrm{O}}=0 \mathrm{~V}, \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \end{aligned}$ | $70$ +3 | $\begin{aligned} & 25 \\ & 1.2 \end{aligned}$ | $\begin{aligned} & 1.75 \\ & \pm 18 \end{aligned}$ | dB <br> mA <br> V |
| DYNAMIC PERFORMANCE <br> Slew Rate <br> Full-Power Bandwidth <br> Settling Time Gain Bandwidth Product Phase Margin | $\begin{aligned} & \mathrm{SR} \\ & \mathrm{BW}_{\mathrm{p}} \\ & \mathrm{t}_{\mathrm{s}} \\ & \mathrm{GBP} \\ & \emptyset_{\mathrm{o}} \end{aligned}$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ <br> 1\% Distortion <br> To 0.01\% |  | $\begin{aligned} & 15 \\ & 50 \\ & 1.5 \\ & 5 \\ & 56 \end{aligned}$ |  | $\mathrm{V} / \mathrm{\mu}$ <br> kHz <br> $\mu \mathrm{s}$ <br> MHz <br> degrees |
| NOISE PERFORMANCE <br> Voltage Noise Voltage Noise Density Current Noise Density | $\begin{aligned} & e_{n p-p} \\ & e_{n} \\ & i_{n} \end{aligned}$ | $\begin{aligned} & 0.1 \mathrm{~Hz} \text { to } 10 \mathrm{~Hz} \\ & \mathrm{f}=1 \mathrm{kHz} \end{aligned}$ |  | $\begin{aligned} & 2 \\ & 10 \\ & 0.4 \end{aligned}$ |  | $\mu \mathrm{V}$ p-p <br> $\mathrm{nV} / \mathrm{NHz}$ <br> $\mathrm{pA} / \sqrt{ } \mathrm{Hz}$ |

NOTES
${ }^{1}$ Long term offset voltage is guaranteed by a 1000 hour life test performed on three independent lots at $+125^{\circ} \mathrm{C}$, with an LTPD of 1.3 .
Specifications subject to change without notice.

## WAFER TEST LIMITS $\left(\mathrm{V}_{\mathrm{s}}=+5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right.$ unless otherwise notete)

| Parameter | Symbol | Conditions | Limit | Units |
| :--- | :--- | :--- | :--- | :--- |
| Offset Voltage | $\mathrm{V}_{\mathrm{OS}}$ | $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~V}_{\mathrm{O}}=0 \mathrm{~V}$ | 1.0 | mV max |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ | $\mathrm{V}_{\mathrm{CM}}=2.5 \mathrm{~V}$ | $\pm 600$ | $\pm 50$ |
| Input Offset Current | $\mathrm{I}_{\mathrm{Os}}$ | $\mathrm{V}_{\mathrm{CM}}=2.5 \mathrm{~V}$ | $\mathrm{nA} \max$ |  |
| Common-Mode Rejection | CMRR | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ to 3.5 V | 70 | $\mathrm{nA} \max$ |
| Power Supply Rejection Ratio | PSRR | $\mathrm{V}= \pm 2.5 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | 70 | dB min |
| Large Signal Voltage Gain | $\mathrm{A}_{\mathrm{VO}}$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, 0.2 \leq \mathrm{V}_{\mathrm{O}} \leq 3.8 \mathrm{~V}$ | 100 | dB min |
| Output Voltage High | $\mathrm{V}_{\mathrm{OH}}$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | 4.0 | $\mathrm{~V} / \mathrm{mV} \mathrm{min}$ |
| Output Voltage Low | $\mathrm{V}_{\mathrm{OL}}$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | 75 | Vmin |
| Supply Current/Amplifier | $\mathrm{I}_{\mathrm{SY}}$ | $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~V}_{\mathrm{O}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=\infty$ | 1.5 | mV max |

[^184]ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

| Supply Voltage | V |
| :---: | :---: |
| Input Voltage | $\pm 18 \mathrm{~V}$ |
| Differential Input Voltage ${ }^{2}$ | $\pm 7 \mathrm{~V}$ |
| Output Short-Circuit Duration to GND | Indefinite |
| Storage Temperature Range |  |
| P, S Package | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Operating Temperature Range |  |
| OP183/OP283G | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Junction Temperature Range |  |
| P, S Package | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Lead Temperature Range (Soldering 60 Sec ) | $+300^{\circ} \mathrm{C}$ |


| Package Type | $\theta_{\mathrm{JA}}{ }^{3}$ | $\theta_{\mathrm{JC}}$ | Units |
| :--- | :---: | :---: | :---: |
| 8-Pin Plastic DIP (P) | 103 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin SOIC (S) | 158 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTES

${ }^{1}$ Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
${ }^{2}$ For supply voltages less than $\pm 7 \mathrm{~V}$, the absolute maximum input voltage is equal to the supply voltage. Maximum input current should not exceed 2 mA . ${ }^{3} \theta_{\mathrm{JA}}$ is specified for the worst case conditions, i.e., $\theta_{\mathrm{JA}}$ is specified for device in socket for P-DIP packages; $\theta_{\mathrm{JA}}$ is specified for device soldered in circuit board for SOIC packages.

ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| OP183GP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | N-8 |
| OP183GS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin SOIC | SO-8 |
| OP183GBC | $+25^{\circ} \mathrm{C}$ | DICE |  |
| OP283GP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | N-8 |
| OP283GS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin SOIC | SO-8 |
| OP283GBC | $+25^{\circ} \mathrm{C}$ | DICE |  |

*For outline information see Package Information section.

DICE CHARACTERISTICS


OP183 Die Size 0.058 X 0.063 Inch, 3,717 Sq. Mils Substrate (Die Backside) Is Connected to $V$-. Transistor Count, 30.


OP283 Die Size $0.063 \times 0.092$ Inch, 5,796 Sq. Mils Substrate (Die Backside) Is Connected to V-. Transistor Count, 55.

## OP183/OP283-Typical Characteristics



Figure 1. OP183 Input Offset Voltage Distribution @+5 V


Figure 4. OP283 Input Offset Voltage Distribution @ $\pm 15$ V


Figure 7. OP283 Input Offset Voltage Drift (TCV ${ }_{\text {os }}$ ) Distribution @ +5 V


Figure 2. OP183 Input Offset Voltage Distribution @ $\pm 15$ V


Figure 5. OP183 Input Offset Voltage Drift (TCV ${ }_{\text {os }}$ ) Distribution @+5 V


Figure 8. OP283 Input Offset Voltage
Drift (TCV ${ }_{\text {os }}$ ) Distribution @ $\pm 15$ V


Figure 3. OP283 Input Offset Voltage Distribution @+5 V


Figure 6. OP183 Input Offset Voltage Drift (TCV os ) Distribution @ $\pm 15$ V


Figure 9. OP183/OP283 Maximum Output Swing vs. Frequency @ +3 V


Figure 10. OP183/OP283 Maximum Output Swing vs. Frequency @+5 V


Figure 11. OP183/OP283 Maximum Output Swing vs. Frequency @ $\pm 15$ V


Figure 13. Input Bias Current vs. Common-Mode Voltage


Figure 16. Supply Current per Amplifier vs. Supply Voltage


Figure 14. Input Bias Current vs. Temperature


Figure 17. Short-Circuit Current vs. Temperature @+5 V


Figure 12. Output Voltage vs. Sink \& Source Current


Figure 15. Supply Current per Amplifier vs. Temperature


Figure 18. Short-Circuit Current vs. Temperature @ $\pm 15$ V

## OP183/OP283-Typical Characteristics



Figure 19. Common-Mode Rejection vs. Frequency


Figure 22. Open-Loop Gain and Phase vs. Frequency @+5 V


Figure 25. Closed-Loop Gain vs. Frequency


Figure 20. Power Supply Rejection vs. Frequency


Figure 23. Open-Loop Gain and Phase vs. Frequency @ $\pm 15$ V


Figure 26. Slew Rate vs. Temperature


Figure 28. Current Noise Density vs. Frequency


Figure 31. Large Signal Performance @ $\pm 15$ V


Figure 29. Closed-Loop Output Impedance vs. Frequency


Figure 32. Small Signal Performance @ $\pm 15$ V


Figure 30. Small Signal Overshoot vs. Load Capacitance
 @ $\pm 2.5 \mathrm{~V}$


Figure 35. THD + Noise vs. Frequency for Various Loads

## APPLICATIONS

## OP183 Offset Adjust

Figure 36 shows how the OP183's offset voltage can be adjusted by connecting a potentiometer between Pins 1 and 5 , and connecting the wiper to $\mathrm{V}_{\mathrm{EE}}$. The recommended value for the potentiometer is $10 \mathrm{k} \Omega$. This will give an adjustment range of approximately $\pm 1 \mathrm{mV}$. If a larger adjustment span is desired, a $50 \mathrm{k} \Omega$ potentiometer will yield a range of $\pm 2.5 \mathrm{mV}$.


Figure 36. OP183 Offset Adjust

## Phase Reversal

The OP183 family is protected against phase reversal as long as both of the inputs are within the range of the positive supply and the negative supply minus 0.6 volts. However if there is a possibility of either input going beyond these limits, then the inputs should be protected with a series resistor to limit input current to 2 mA .

## Direct Access Arrangement

The OP183/OP283 can be used in a single supply Direct Access Arrangement (DAA) as is shown in Figure 37. This figure shows a portion of a typical DAA capable of operating from a single +5 volt supply and it should also work on +3 volt supplies with minor modifications. Amplifiers A2 and A3 are configured so that the transmit signal TXA is inverted by A2 and is not inverted by A3. This arrangement drives the transformer differentially so that the drive to the transformer is effectively doubled over a single amplifier arrangement. This application takes advantage of the OP183/283's ability to drive capacitive loads, and to save power in single supply applications.


Figure 37. Direct Access Arrangement

## +5 Volt Only Stereo DAC for Multimedia

The OP283's low noise and single supply capability are ideally suited for stereo DAC audio reproduction or sound synthesis applications such as multimedia systems. Figure 38 shows an 18 -bit stereo DAC output setup that is powered from a single +5 volt supply. The low noise preserves the 18 -bit dynamic range of the AD1868. For DACs that operate on dual supplies, the OP283 can also be powered from the same supplies.


Figure 38. +5 Volt Only 18-Bit Stereo DAC

## Low Voltage Headphone Amplifiers

Figure 39 shows a stereo headphone output amplifier for the AD1849 16-bit SoundPort ${ }^{\circledR}$ Stereo Codec device. The pseudoreference voltage is derived from the common-mode voltage generated internally by the AD1849, thus providing a convenient bias for the headphone output amplifiers.


Figure 39. Headphone Output Amplifier for Multimedia Sound Codec
SoundPort is a registered trademark of Analog Devices Inc.

## Low Noise Microphone Amplifier for Multimedia

The OP183 family is ideally suited as a low noise microphone preamp for low voltage audio applications. Figure 40 shows a gain of 100 stereo preamp for the AD1 849 16-bit SoundPort Stereo Codec chip. The common-mode output buffer serves as a "phantom power" driver for the microphones.


Figure 40. Low Noise Stereo Microphone Amplifier for Multimedia Sound CODEC

A +3 Volt $50 \mathrm{~Hz} / 60 \mathrm{~Hz}$ Active Notch Filter with False Ground To process ac signals, it may be easier to use a false-ground bias rather than the negative supply as a reference ground. This would reject the power-line frequency interference which oftentimes can obscure low frequency physiological signals, such as heart rates, blood pressures, EEGs, ECGs, et cetera.
Figure 41 shows a $50 \mathrm{~Hz} / 60 \mathrm{~Hz}$ active notch filter for eliminating line noise in patient monitoring equipment. It has several kilohertz


Figure 41. +3 Volt Supply $50 \mathrm{~Hz} / 60 \mathrm{~Hz}$ Notch Filter with Pseudo Ground
bandwidth and is not sensitive to false-ground perturbations. The simple false-ground circuit shown achieves good rejection of low frequency interference using standard off-the-shelf components.

Amplifier A3 biases A1 and A2 to the middle of their input common-mode range. When operating on a +3 V supply, the center of the OP283's common-mode range is 0.75 V . This notch filter effectively squelches 60 Hz pickup at a filter Q of 0.75 . To reject 50 Hz interference, simply change the resistors in the twin-T section (R1 through R5) from $2.67 \mathrm{k} \Omega$ to $3.16 \mathrm{k} \Omega$.
The filter section uses an OP283 dual op amp in a twin-T configuration whose frequency selectivity is very sensitive to the relative matching of the capacitors and resistors in the twin- T section. Mylar is the material of choice for the capacitors, and the relative matching of the capacitors and resistors determines the filter's pass band symmetry. Using $1 \%$ resistors and $5 \%$ capacitors produces satisfactory results.

## A Low Voltage Frequency Synthesizer for Wireless Transceiver

The OP183's low noise and the low voltage operation capability serves well for the loop filter of a frequency synthesizer. Figure 42 shows a typical application in a radio transceiver. The phase noise performance of the synthesizer depends on low noise contribution from each component in the loop as the noise is amplified by the frequency division factor of the prescaler.


Figure 42. A Low Voltage Frequency Synthesizer for a Wireless Transceiver

The resistors used in the low-pass filter should be of low to moderate values to reduce noise contribution due to the input bias current as well as the resistors themselves. The filter cutoff frequency should be chosen to optimize the loop constant.


Figure 43. OP183 Simplified Schematic



## FEATURES

- Low Input Offset Voltage
$75 \mu \mathrm{~V}$ Max
- Low Offset Voltage Drift, Over $-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ $0.5 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ Max
- Low Supply Current (Per Amplifier) 725 $\mu$ A Max
- High Open-Loop Gain . . . . . . . . . . . . . . . . . . . . 5000V/mV Min
- Low Input Bias Current . . . . . . . . . . . . . . . . . . . . . . . 2nA Max
- Low Noise Voltage Density . . . . . . . . . . . 11nV/ $\sqrt{\mathrm{Hz}}$ at 1kHz
- Stable With Large Capacitive Loads ............. 10nF Typ
- Pin Compatible to OP-14, OP-221, LM158, MC1458/1558, and LT1013 With Improved Performance
- Available in Die Form


## ORDERING INFORMATION ${ }^{\dagger}$

| $\begin{gathered} T_{A}=+25^{\circ} \mathrm{C} \\ \mathrm{~V}_{\mathrm{OS}}^{\mathrm{MAXX}} \\ (\mu \mathrm{~V}) \end{gathered}$ | PACKAGE |  |  | OPERATING TEMPERATURE RANGE |
| :---: | :---: | :---: | :---: | :---: |
|  | $\begin{aligned} & \text { CERDIP } \\ & \text { 8-PIN } \end{aligned}$ | PLASTIC | $\begin{gathered} \text { LCC } \\ \text { 20-CONTACT } \end{gathered}$ |  |
| 75 | OP200AZ* | - | OP200ARC* | MIL |
| 75 | OP200EZ | - | - | XIND |
| 150 | OP200FZ | - | - | XIND |
| 200 | - | OP200GP | - | XIND |
| 200 | - | OP200GS ${ }^{\dagger \dagger}$ | - | XIND |

- For devices processed in total compliance to MIL-STD-883, add /883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.
It For availability and burn-in information on SO and PLCC packages, contact your local sales office.


## GENERAL DESCRIPTION

The OP-200 is the first monolithic dual operational amplifier to offer OP-77 type precision performance. Available in the industry standard 8-pin pinout, the OP-200 combines precision performance with the space and cost savings offered by a dual amplifier.
The OP-200 features an extremely low input offset voltage of less than $75 \mu \mathrm{~V}$ with a drift below $0.5 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$, guaranteed over the

PIN CONNECTIONS

LCC
(RC-Suffix)


EPOXY MINI-DIP (P-Suffix) 8-PIN HERMETIC DIP
(Z-Suffix)


SIMPLIFIED SCHEMATIC (One of two amplifiers is shown.)


This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.
full military temperature range. Open-loop gain of the OP-200 exceeds $5,000,000$ into a $10 \mathrm{k} \Omega$ load; input bias current is under 2 nA ; CMR is over 120 dB and PSRR below $1.8 \mu \mathrm{~V} / \mathrm{V}$. On-chip zener-zap trimming is used to achieve the extremely low input offset voltage of the OP-200 and eliminates the need for offset nulling.
Power consumption of the OP-200 is very low, with each amplifier drawing less than $725 \mu \mathrm{~A}$ of supply current. The total current drawn by the dual OP-200 is less than one-half that of a single OP-07, yet the OP-200 offers significant improvements over this industry standard op amp. The voltage noise density of the OP-200, $11 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ at 1 kHz , is half that of most competitive devices.
The OP-200 is pin compatible with the OP-14, OP-221, LM158, MC1458/1558, and LT1013 and can be used to upgrade systems using these devices. The OP-200 is an ideal choice for applications requiring multiple precision op amps and where low power consumption is critical.
For a quad precision op amp, see the OP-400.

| ABSOLUTE MAXIMUM RATINGS (Note 1) |  |  |  |
| :---: | :---: | :---: | :---: |
| Supply Voltage |  |  |  |
| Differential Input Voltage ............................................ $\pm 30 \mathrm{~V}$ |  |  |  |
| Input Voltage .............................................. Supply Voltage |  |  |  |
| Output Short-Circuit Duration ............................. Continuous |  |  |  |
| Storage Temperature Range |  |  |  |
| P, RC, S, Z-Package .............................. $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |  |  |  |
| Lead Temperature Range (Soldering, 60 sec ) ............. $300^{\circ} \mathrm{C}$ |  |  |  |
| Junction Temperature ( $\mathrm{T}_{\text {) }}$ ) ......................... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |  |  |  |
| Operating Temperature Range |  |  |  |
| OP-200A ............................................... $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  |  |  |
| OP-200E, OP-200F .................................. $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  |  |
| OP-200G ................................................ $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  |  |
| PACKAGE TYPE | $\boldsymbol{\Theta}_{\mathbf{1 A}}$ ( Note 2) | $\theta_{\text {Jc }}$ | UNITS |
| 8-Pin Hermetic DIP (Z) | 148 | 16 | ${ }^{\circ} \mathrm{CN}$ |
| 8 -Pin Plastic DIP (P) | 96 | 37 | ${ }^{\circ} \mathrm{CNW}$ |
| 20-Contact LCC (RC) | 88 | 33 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $16-\mathrm{Pin} \mathrm{SOL} \mathrm{(S)}$ | 92 | 27 | ${ }^{\text {C/N }}$ |
| NOTES: |  |  |  |
| 1. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted. |  |  |  |
|  |  |  |  |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.

|  |  |  | OP-200A/E |  |  | OP-200F |  |  | OP-200G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Input Offset Voltage | $\mathrm{V}_{\mathrm{OS}}$ |  | - | 25 | 75 | - | 50 | 150 | - | 80 | 200 | $\mu \mathrm{V}$ |
| Long Term Input Voltage Stability |  |  | - | 0.1 | - | - | 0.1 | - | - | 0.1 | - | $\mu \mathrm{V} / \mathrm{mo}$ |
| Input Offset Current | los | $\mathrm{V}_{\mathrm{CM}}=\mathrm{OV}$ | - | 0.05 | 1.0 | - | 0.05 | 2.0 | - | 0.05 | 3.5 | nA |
| Input Bias Current | $I_{B}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 0.1 | 2.0 | - | 0.1 | 4.0 | - | 0.1 | 5.0 | nA |
| Input Noise Voltage | $e_{n p-p}$ | 0.1 Hz to 10 Hz | - | 0.5 | - | - | 0.5 | - | - | 0.5 | - | $\mu V_{p-p}$ |
| Input Noise Voltage Density | $e_{n}$ | $\left.\begin{array}{l} f_{\mathrm{O}}=10 \mathrm{~Hz} \\ f_{\mathrm{O}}=1000 \mathrm{~Hz} \end{array} \text { (Note } 1\right)$ | - | $\begin{aligned} & 22 \\ & 11 \end{aligned}$ | $\begin{aligned} & 36 \\ & 18 \end{aligned}$ | - | 22 11 | $\begin{aligned} & 36 \\ & 18 \end{aligned}$ | - | $\begin{aligned} & 22 \\ & 11 \end{aligned}$ | - | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| Input Noise Current | $i_{n p-p}$ | 0.1 Hz to 10 Hz | - | 15 | - | - | 15 | - | - | 15 | - | $p A_{p-p}$ |
| Input Noise Current Density | $i_{n}$ | $\mathrm{f}_{\mathrm{O}}=10 \mathrm{~Hz}$ | - | 0.4 | - | - | 0.4 | - | - | 0.4 | - | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
| Input Resistance Differential Mode | $\mathrm{R}_{\text {IN }}$ |  | - | 10 | - | - | 10 | - | - | 10 | - | $\mathrm{M} \Omega$ |
| Input Resistance Common Mode | $\mathrm{R}_{\text {INCM }}$ |  | - | 125 | - | - | 125 | - | - | 125 | - | G $\Omega$ |
| Large Signal Voltage Gain | Avo | $\begin{gathered} \mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \\ \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \\ \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \end{gathered}$ | $\begin{aligned} & 5000 \\ & 2000 \end{aligned}$ | $\begin{array}{r} 12000 \\ 3700 \end{array}$ | - | $\begin{aligned} & 3000 \\ & 1500 \end{aligned}$ | $\begin{aligned} & 7000 \\ & 3200 \end{aligned}$ | - | $\begin{aligned} & 3000 \\ & 1500 \end{aligned}$ | $\begin{aligned} & 7000 \\ & 3200 \\ & \hline \end{aligned}$ | - | $\mathrm{V} / \mathrm{mV}$ |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted. (Continued)

| PARAMETER | SYMBOL | CONDITIONS | OP-200A/E |  |  | OP-200F |  |  | OP-200G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Input Voltage Range | IVR | (Note 3) | $\pm 12$ | $\pm 13$ | - | $\pm 12$ | $\pm 13$ | - | $\pm 12$ | $\pm 13$ | - | v |
| Common-Mode Rejection | CMR | $\mathrm{V}_{\mathrm{CM}}= \pm 12 \mathrm{~V}$ | 120 | 135 | - | 115 | 135 | - | 110 | 130 | - | dB |
| Power Supply Rejection Ratio | PSRR | $\mathrm{V}_{\mathrm{S}}= \pm 3 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | 0.4 | 1.8 | - | 0.4 | 3.2 | - | 0.6 | 5.6 | $\mu \mathrm{V} / \mathrm{V}$ |
| Output Voltage Swing | $\mathrm{v}_{0}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \end{aligned}$ | $\begin{aligned} & \pm 12 \\ & \pm 11 \end{aligned}$ | $\begin{aligned} & \pm 12.6 \\ & \pm 12.2 \end{aligned}$ | - | $\begin{aligned} & \pm 12 \\ & \pm 11 \end{aligned}$ | $\begin{aligned} & \pm 12.6 \\ & \pm 12.2 \end{aligned}$ | - | $\begin{aligned} & \pm 12 \\ & \pm 11 \end{aligned}$ | $\begin{aligned} & \pm 12.6 \\ & \pm 12.2 \end{aligned}$ |  | v |
| Supply Current Per Amplifier | $\mathrm{I}_{\mathrm{sr}}$ | No Load | - | 570 | 725 | - | 570 | 725 | - | 570 | 725 | $\mu \mathrm{A}$ |
| Slew Rate | SR |  | 0.1 | 0.15 | - | 0.1 | 0.15 | - | 0.1 | 0.15 | - | $\mathrm{V} / \mu \mathrm{s}$ |
| Gain Bandwidth Product | GBWP | $A_{V}=+1$ | - | 500 | - | - | 500 | - | - | 500 | - | kHz |
| Channel Separation | CS | $\begin{aligned} & v_{\mathrm{O}}=20 \mathrm{v}_{\mathrm{p}-\mathrm{p}} \\ & \mathrm{f}_{\mathrm{O}}=10 \mathrm{~Hz}(\text { Note 2) } \end{aligned}$ | 123 | 145 | - | 123 | 145 | - | 123 | 145 | - | dB |
| Input Capacitance | $\mathrm{C}_{\text {IN }}$ |  | - | 3.2 | - | - | 3.2 | - | - | 3.2 | - | pF |
| Capacitive Load Stability |  | $A_{V}=+1$ <br> No Oscillations | - | 10 | - | - | 10 | - | - | 10 | - | nF |

NOTES:

1. Sample tested.
2. Guaranteed but not $100 \%$ tested.
3. Guaranteed by CMR test.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}=+15 \mathrm{~V},-55^{\circ} \mathrm{C} \leq T_{A} \leq 125^{\circ} \mathrm{C}$ for $\mathrm{OP}-200 \mathrm{~A}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-200A |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX |  |
| Input Offset Voltage | $\mathrm{v}_{\text {os }}$ |  | - | 45 | 125 | $\mu \mathrm{V}$ |
| Average Input Offset Voltage Drift | TCV ${ }_{\text {os }}$ |  | - | 0.2 | 0.5 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current | Ios | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 0.15 | 2.5 | nA |
| Input Bias Current | $I_{B}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 0.9 | 5.0 | nA |
| Large Signal Voltage Gain | Avo | $\begin{aligned} & \mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{L}}=10 \Omega \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & \hline \end{aligned}$ | $\begin{aligned} & 3000 \\ & 1000 \\ & \hline \end{aligned}$ | $\begin{aligned} & 9000 \\ & 2700 \\ & \hline \end{aligned}$ |  | V/mV |
| Input Voltage Range | IVR | (Note 1) | $\pm 12$ | $\pm 12.5$ | - | V |
| Common-Mode Rejection | CMR | $\mathrm{V}_{\text {CM }}= \pm 12 \mathrm{~V}$ | 115 | 130 | - | dB |
| Power Supply Rejection Ratio | PSRR | $\mathrm{V}_{\mathrm{S}}= \pm 3 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | 0.2 | 3.2 | $\mu \mathrm{V} / \mathrm{V}$ |
| Output Voltage Swing | $V_{0}$ | $\begin{aligned} & R_{\mathrm{L}}=10 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & \hline \end{aligned}$ | $\begin{aligned} & \pm 12 \\ & \pm 11 \\ & \hline \end{aligned}$ | $\begin{array}{r}  \pm 12.4 \\ \pm 12 \\ \hline \end{array}$ | - | v |
| Supply Current <br> Per Amplifier | $\mathrm{I}_{\text {Sr }}$ | No Load | - | 600 | 775 | $\mu \mathrm{A}$ |
| Capacitive Load Stability |  | $A_{V}=+1$ <br> No Oscillations | - | 8 | - | nF |

## NOTES:

1. Guaranteed by CMR test.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-200E |  |  | OP-200F |  |  | OP-200G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Input Offset Voltage | $\mathrm{V}_{\text {OS }}$ |  | - | 35 | 100 | - | 80 | 250 | - | 110 | 300 | $\mu \mathrm{V}$ |
| Average Input Offset Voltage Drift | $\mathrm{TCV}_{\text {os }}$ |  | - | 0.2 | 0.5 | - | 0.5 | 1.5 | - | 0.6 | 2.0 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current | Ios | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 0.08 | 2.5 | - | 0.08 | 3.5 | - | 0.1 | 6.0 | nA |
| Input Bias Current | $I_{B}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 0.3 | 5.0 | - | 0.3 | 7.0 | - | 0.5 | 10.0 | nA |
| Large-Signal Voltage Gain | $A_{\text {vo }}$ | $\begin{gathered} V_{\mathrm{O}}= \pm 10 \mathrm{~V} \\ R_{\mathrm{L}}=10 \mathrm{k} \Omega \\ R_{\mathrm{L}}=2 \mathrm{k} \Omega \end{gathered}$ | $\begin{aligned} & 3000 \\ & 1500 \end{aligned}$ | $\begin{array}{r} 10000 \\ 3200 \end{array}$ | $-$ | $\begin{aligned} & 2000 \\ & 1000 \end{aligned}$ | $\begin{aligned} & 5000 \\ & 2500 \end{aligned}$ | - | $\begin{aligned} & 2000 \\ & 1000 \end{aligned}$ | $\begin{aligned} & 5000 \\ & 2500 \\ & \hline \end{aligned}$ | - | V/mV |
| Input Voltage Range | IVR | (Note 1) | $\pm 12$ | $\pm 12.5$ | - | $\pm 12$ | $\pm 12.5$ | - | $\pm 12$ | $\pm 12.5$ | - | V |
| Common-Mode Rejection | CMR | $\mathrm{V}_{\mathrm{CM}}= \pm 12 \mathrm{~V}$ | 115 | 130 | - | 110 | 130 | - | 105 | 130 | - | dB |
| Power Supply <br> Rejection Ratio | PSRR | $\mathrm{V}_{S}= \pm 3 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | 0.15 | 3.2 | - | 0.15 | 5.6 | - | 0.3 | 10.0 | $\mu \mathrm{V} / \mathrm{V}$ |
| Output Voltage Swing | $\mathrm{V}_{0}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \end{aligned}$ | $\begin{aligned} & \pm 12 \\ & \pm 11 \end{aligned}$ | $\begin{array}{r}  \pm 12.4 \\ \pm 12 \\ \hline \end{array}$ | - | $\begin{aligned} & \pm 12 \\ & \pm 11 \end{aligned}$ | $\begin{array}{r}  \pm 12.4 \\ \pm 12 \end{array}$ | - | $\begin{aligned} & \pm 12 \\ & \pm 11 \end{aligned}$ | $\begin{aligned} & \pm 12.4 \\ & \pm 12.2 \\ & \hline \end{aligned}$ | - | V |
| Supply Current <br> Per Amplifier | $\mathrm{I}_{\mathrm{sy}}$ | No Load | - | 600 | 775 | - | 600 | 775 | - | 600 | 775 | $\mu \mathrm{A}$ |
| Capacitive Load Stability |  | $A_{V}=+1$ <br> No Oscillations | - | 10 | - | - | 10 | - | - | 10 | - | $n \mathrm{~F}$ |

## NOTES:

1. Guaranteed by CMR test.

## CHANNEL SEPARATION TEST CIRCUIT



NOISE TEST SCHEMATIC


## FEATURES

```
- Excellent TCV os Match
\(2 \mu V /{ }^{\circ}\) C Max
- Low Input Offset Voltage \(150 \mu V\) Max
- Low Supply Current . . . . . . . . . . . . . . . . . . . . . . . . . . . . \(100 \mu \mathrm{~A}\)
- Single-Supply Operation ................... +5 V to +30 V
- Low Input Offset Voltage Drift ............... \(0.75 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}\)
- High Open-Loop Gain . . . . . . . . . . . . . . . . . . . . . . 2000V/mV
- High PSRR ................................................. \(3 \mu \mathrm{~V} / \mathrm{V}\)
- Low Input Bias Current ................................. . 12nA
- Wide Common-Mode Voltage
Range . . . . . . . . . . . . . . . . . . . . V- to within 1.5V of V+
- Pin Compatible with 1458, LM158, LM2904
- Available in Die Form
```


## GENERAL DESCRIPTION

The OP-220 is a monolithic dual operational amplifier that can be used either in single or dual supply operation. The low offset voltage, and input offset voltage tracking as low as $1.0 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$, make this the first micropower precision dual operational amplifier.
The excellent specifications of the individual amplifiers combined with the tight matching and temperature tracking between channels provides high performance in instrumentation amplifier designs. The individual amplifiers feature extremely low input offset voltage, low offset voltage drift, low noise voltage, and low bias current. They are fully compensated and protected.
Matching between channels is provided on all critical parameters including input offset voltage, tracking of offset voltage vs. temperature, non-inverting bias currents, and common-mode rejection ratios.

ORDERING INFORMATION ${ }^{\dagger}$

| $\begin{gathered} \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ \hat{\mathrm{~V}}_{\mathrm{OS}} \text { MAX } \\ (\mu \mathrm{V}) \end{gathered}$ | PACKAGE |  |  | OPERATINGTEMPERATURE RANGE |
| :---: | :---: | :---: | :---: | :---: |
|  | TO-99 | CERDIP 8-PIN | PLASTIC 8-PIN |  |
| 150 | OP220AJ* | OP220AZ | - | MIL |
| 150 | - | OP220EZ | - | IND |
| 300 | - | OP220FZ | - | IND |
| 750 | OP220CJ* | OP220CZ | - | MIL |
| 750 | OP220GJ | OP220GZ | OP220GP | XIND |
| 750 | - | - | OP220GS | XIND |

- For devices processed in total compliance to MIL-STD-883, add/883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.


## PIN CONNECTIONS



## SIMPLIFIED SCHEMATIC (Each Amplifier)


*ACCESSIBLE IN CHIP FORM ONLY

This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 2.5 \mathrm{~V}$ to $\pm 15 \mathrm{~V},-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ for OP-220A and $\mathrm{C},-25^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ for OP-220E and $F,-40^{\circ} \mathrm{C} \leq T_{A} \leq+85^{\circ} \mathrm{C}$ for OP-220G, unless otherwise noted. Continued

| PARAMETER | 8YMBOL | CONDITIONS | OP-220AE |  |  | OP-220F |  |  | OP-220C/G |  |  | UNIT8 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | YP | max | MIN | TYP | max | MIN | TYP | max |  |
| Large-Signal Voltage Gain | Avo | $\begin{aligned} & V_{S}= \pm 15 \mathrm{~V}, R_{L}=50 \mathrm{k} \Omega \\ & V_{O}= \pm 10 \mathrm{~V} \end{aligned}$ | 500 | 1000 | - | 500 | 800 | - | 400 | 500 | - | V/mV |
| Output Voltage Swing | $\mathrm{v}_{0}$ | $\begin{aligned} & \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V}, \\ & R_{\mathrm{L}}=20 \mathrm{k} \Omega \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \mathrm{k} \Omega \end{aligned}$ | $\begin{array}{r} 0.9 / 3.8 \\ \pm 13.8 \end{array}$ | - | - | 0.9/3.8 $\pm 13.8$ | - | - | $1 / 3.8$ $\pm 13.8$ | - | - | $v$ |
| Supply Current (Both Amplifiers) | $1 \mathrm{l} \gamma$ | $\begin{aligned} & V_{S}= \pm 2.5 \mathrm{~V} \text {, No Load } \\ & \mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V} \text {, No Load } \end{aligned}$ | - | $\begin{aligned} & 135 \\ & 190 \end{aligned}$ | $\begin{aligned} & 170 \\ & 250 \end{aligned}$ | - | 155 200 | $\begin{aligned} & 185 \\ & 280 \end{aligned}$ | - | 170 275 | $\begin{aligned} & 210 \\ & 330 \end{aligned}$ | $\mu \mathrm{A}$ |

NOTE: 1. Sample tested.
MATCHING CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.

|  |  |  | OP-220AVE |  |  | OP-220F |  |  | OP-220C/G |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | UNIT8 |
| Input Offset Voltage Match | $\Delta V_{\text {OS }}$ |  | - | 150 | 300 | - | 250 | 500 | - | 300 | 600 | $\mu \mathrm{V}$ |
| Average Noninverting Bias Current | $\mathrm{I}_{\mathrm{B}}+$ | $V_{C M}=0$ | - | 10 | 20 | - | 15 | 25 | - | 20 | 30 | nA |
| Noninverting Offset Current | 'os+ | $V_{C M}=0$ | - | 0.7 | 1.5 | - | 1 | 2 | - | 1.4 | 2.5 | nA |
| Common-Mode Rejection Ratio Match (Note 1) | $\Delta$ CMRR | $V_{C M}=-15 \mathrm{~V}$ to +13.5 V | 92 | 100 | - | 87 | 95 | - | 72 | 85 | - | dB |
| Power Supply Rejection Ratio Match (Note 2) | $\triangle$ PSRR | $V_{S}= \pm 2.5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$ | - | 6 | 14 | - | 18 | 44 | - | 57 | 140 | $\mu \mathrm{V} / \mathrm{V}$ |

MATCHING CHARACTERISTICS at $\mathrm{V}_{S}= \pm 15 \mathrm{~V},-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ for OP-220A and $\mathrm{C} ;-25^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ for $\mathrm{OP}-220 \mathrm{E}$ and $\mathrm{F} ;-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ for $\mathrm{OP}-220 \mathrm{G}$, unless otherwise noted. Grades $\mathrm{E}, \mathrm{F}$ are sample tested.




| PACKAGE TYPE | $\theta_{J A}$ (Note 2) | $\theta_{16}$ | UNITS |
| :---: | :---: | :---: | :---: |
| TO-99 (J) | 150 | 18 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin Hermetic DIP (Z) | 148 | 16 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin Plastic DIP (P) | 103 | 43 | ${ }^{\circ} \mathrm{CM}$ |
| 8-Pin SO (S) | 158 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

NOTES:

1. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
2. $\Theta_{j A}$ is specified for worst case mounting conditions, i.e., $\Theta_{j A}$ is specified for device in socket for CerDIP and P-DIP packages; $\boldsymbol{\theta}_{\mid A}$ is specified for device soldered to printed circuit board for SO package.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 2.5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | 8YMBOL | CONDITIONS | OP-220A/E |  |  | OP-220F |  |  | OP-220C/G |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | UNITS |
| Input Offset Voltage | V OS | $\mathrm{V}_{\mathrm{S}}= \pm 2.5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$ | - | 120 | 150 | - | 250 | 300 | - | 500 | 750 | $\mu \mathrm{V}$ |
| Input Offset Current | los | $V_{C M}=0$ | - | 0.15 | 1.5 | - | 0.2 | 2 | - | 0.2 | 3.5 | nA |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ | $V_{C M}=0$ | - | 12 | 20 | - | 13 | 25 | - | 14 | 30 | $n \mathrm{~A}$ |
| Input Voltage Range | IVR | $\begin{aligned} & V+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V} \end{aligned}$ | $\begin{array}{r} 0 / 3.5 \\ -15 / 13.5 \end{array}$ | - | - | $\begin{array}{r} 0 / 3.5 \\ -15 / 13.5 \end{array}$ | - | - | $\begin{array}{r} 0 / 3.5 \\ -15 / 13.5 \end{array}$ | - | - | V |
| Common-Mode Rejection Ratio | CMRR | $\begin{aligned} & \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V}, \\ & \mathrm{OV} \leq \mathrm{V}_{\mathrm{CM}} \leq 3.5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \\ & -15 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CM}} \leq 13.5 \mathrm{~V} \end{aligned}$ | 90 95 | 100 100 | - - | 85 90 | 90 95 | - | 75 80 | 85 90 | - | dB |
| Power Supply Rejection Ratio | PSRR | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}= \pm 2.5 \mathrm{~V} \text { to } \pm 15 \mathrm{~V} \\ & \mathrm{~V}-=0 \mathrm{~V}, \mathrm{~V}+=5 \mathrm{~V} \text { to } 30 \mathrm{~V} \end{aligned}$ | - | $\begin{aligned} & 3 \\ & 6 \end{aligned}$ | $\begin{aligned} & 10 \\ & 18 \\ & \hline \end{aligned}$ | - | $\begin{aligned} & 10 \\ & 18 \\ & \hline \end{aligned}$ | $\begin{aligned} & 32 \\ & 57 \\ & \hline \end{aligned}$ | - | $\begin{aligned} & 32 \\ & 57 \end{aligned}$ | $\begin{aligned} & 100 \\ & 180 \end{aligned}$ | $\mu \mathrm{V} / \mathrm{V}$ |
| Large-Signal Voltage Gain | Avo | $\begin{aligned} & \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=100 \mathrm{k} \Omega \\ & 1 \mathrm{~V} \leq \mathrm{V}_{\mathrm{O}} \leq 3.5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=25 \mathrm{k} \Omega \\ & \mathrm{~V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \end{aligned}$ | 500 1000 | 1000 2000 | - | 500 1000 | 800 2000 | - | 300 800 | 500 1600 | - | V/mV |
| Output Voltage Swing | $V_{0}$ | $\begin{aligned} & V+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V} \\ & R_{\mathrm{L}}=10 \mathrm{k} \Omega \\ & V_{S}= \pm 15 \mathrm{~V}, R_{\mathrm{L}}=25 \mathrm{k} \Omega \end{aligned}$ | $\begin{array}{r} 0.7 / 4 \\ \pm 14 \end{array}$ | - | - | $0.7 / 4$ $\pm 14$ | - | - | $0.8 / 4$ $\pm 14$ | - | - | V |
| Slew Rate | SR | $R_{L}=25 \mathrm{k} \Omega$, (Note 1) | - | 0.05 | - | - | 0.05 | - | - | 0.05 | - | $\mathrm{V} / \mathrm{\mu s}$ |
| Bandwidth | BW | $A_{V C L}=+1, R_{L}=25 \mathrm{k} \Omega$ | - | 200 | - | - | 200 | - | - | 200 | - | kHz |
| Supply Current (Both Amplifiers) | Isy | $\begin{aligned} & V_{S}= \pm 2.5 \mathrm{~V}, \text { No Load } \\ & V_{S}= \pm 15 \mathrm{~V} \text {, No Load } \end{aligned}$ | - | $\begin{aligned} & 100 \\ & 140 \\ & \hline \end{aligned}$ | $\begin{aligned} & 115 \\ & 170 \\ & \hline \end{aligned}$ | - | $\begin{aligned} & 115 \\ & 150 . \\ & \hline \end{aligned}$ | $\begin{aligned} & 125 \\ & 190 \\ & \hline \end{aligned}$ | - | $\begin{array}{r} 125 \\ 205 \\ \hline \end{array}$ | $\begin{array}{r} 135 \\ 220 \\ \hline \end{array}$ | $\mu \mathrm{A}$ |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 2.5 \mathrm{~V}$ to $\pm 15 \mathrm{~V},-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ for OP-220A and $\mathrm{C},-25^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ for OP-220E and $F,-40^{\circ} \mathrm{C} \leq T_{A} \leq+85^{\circ} \mathrm{C}$ for OP-220G, unless otherwise noted.

| PARAMETER | 8YMBOL | CONDITIONS | OP-220AE |  |  | OP-220'F |  |  | OP-220C/G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Average Input Offset Voltage Drift (Note 1) | TCVos | $\mathrm{V}_{\mathbf{S}}= \pm 15 \mathrm{~V}$ | - | 0.75 | 1.5 | - | 1.2 | 2 | - | 2 | 3 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Voltage | $\mathrm{V}_{\text {OS }}$ |  | - | 200 | 300 | - | 400 | 500 | - | 1000 | 1300 | $\mu \mathrm{V}$ |
| Input Offset Current | Ios | $V_{C M}=0$ | - | 0.5 | 2 | - | 0.6 | 2.5 | - | 0.8 | 5 | $n \mathrm{~A}$ |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ | $V_{C M}=0$ | - | 12 | 25 | - | 13 | 30 | - | 14 | 40 | $n \mathrm{~A}$ |
| Input Voltage Range | IVR | $\begin{aligned} & \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V} \end{aligned}$ | $\begin{array}{r} 0 / 3.2 \\ -15 / 13.2 \end{array}$ | - | - | $\begin{array}{r} 0 / 3.2 \\ -15 / 13.2 \end{array}$ | - | - | $\begin{array}{r} 0 / 3.2 \\ -15 / 13.2 \end{array}$ | - | - | V |
| Common-Mode Rejection Ratio | CMRR | $\begin{aligned} & \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V}, \\ & 0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CM}} \leq 3.2 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V} \\ & -15 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CM}} \leq 13.2 \mathrm{~V} \\ & \hline \end{aligned}$ | 85 90 | 90 95 | - - | 80 85 | 85 90 | - - | 70 75 | 80 85 | - - | dB |
| Power Supply Rejection Ratio | PSRR | $\begin{aligned} & V_{S}= \pm 2.5 \mathrm{~V} \text { to } \pm 15 \mathrm{~V} \\ & \mathrm{~V}-=0 \mathrm{~V}, \mathrm{~V}+=5 \mathrm{~V} \text { to } 30 \mathrm{~V} \end{aligned}$ | - | $\begin{array}{r} 6 \\ 10 \end{array}$ | $\begin{aligned} & 18 \\ & 32 \end{aligned}$ | - | $\begin{array}{r} 18 \\ 32 \\ \hline \end{array}$ | $\begin{array}{r} 57 \\ 100 \\ \hline \end{array}$ | - | $\begin{array}{r} 57 \\ 100 \\ \hline \end{array}$ | $\begin{array}{r} 180 \\ 320 \\ \hline \end{array}$ | $\mu \mathrm{V} / \mathrm{V}$ |

## FEATURES

| $2 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ |  |  |
| :---: | :---: | :---: |
| Low Input Offset Voitage |  |  |
| Low Supply Current |  |  |
| Single Supply Operation ................ $+5 \mathrm{5V}$ to +30 V |  |  |
|  High Open-Loop Gain .................. . . 1500V/mV Min |  |  |
|  |  |  |
| High PSRR |  |  |
| Wide Common-Mode Voltage |  |  |
| Rang |  |  |
| n Compatible with 1458, LM158, LM2904 |  |  |
|  |  |  |

ORDERING INFORMATION ${ }^{\dagger}$

| $\begin{gathered} \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ \mathrm{~V}_{\text {OS MAX }} \\ (\mu \mathrm{V}) \\ \hline \end{gathered}$ | PACKAGE |  |  | OPERATING TEMPERATURE RANGE |
| :---: | :---: | :---: | :---: | :---: |
|  | TO-99 | $\begin{aligned} & \text { CERDIP } \\ & \text { 8-PIN } \end{aligned}$ | PLASTIC 8-PIN |  |
| 150 | OP-221AJ/883 | OP221AZ* | - | MIL |
| 150 | - | OP221EZ | - | IND |
| 300 | OP221BJ | - | - | MIL |
| 500 | OP221CJ | - | - | MIL |
| 500 | OP221GJ | OP221GZ | OP221GP | XIND |
| 500 | - | - | OP221GS | XIND |

* For devices processed in total compliance to MIL-STD-883, add/883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.


## GENERAL DESCRIPTION

The OP-221 is a monolithic dual operational amplifier that can be used either in single or dual supply operation. The
wide supply voltage range, wide input voltage range, and low supply current drain of the OP-221 make it well-suited for operation from batteries or unregulated power supplies.
The excellent specifications of the individual amplifiers combined with the tight matching and temperature tracking between channels provide high performance in instrumentation amplifier designs. The individual amplifiers feature very low input offset voltage, low offset voltage drift, low noise voltage, and low bias current. They are fully compensated and protected.
Matching between channels is provided on all critical parameters including input offset voltage, tracking of offset voltage vs. temperature, non-inverting bias currents, and common-mode rejection.

PIN CONNECTIONS


SIMPLIFIED SCHEMATIC (Each Amplifier)


This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

| ABSOLUTE MAXIMUM RATINGS (Note 1) <br> Supply Voltage $\qquad$ <br> Differential Input Voltage $\qquad$ 30V or Supply Voltage <br> Input Voltage $\qquad$ Supply Voltage <br> Output Short-Circuit Duration $\qquad$ Indefinite <br> Storage Temperature Range $\qquad$ $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ <br> Operating Temperature Range $\qquad$ $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ <br> OP-221E $\qquad$ $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ <br> OP-221G $\qquad$ $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ <br> Lead Temperature (Soldering, 60 sec ) $\qquad$ $+300^{\circ} \mathrm{C}$ Junction Temperature ( $\mathrm{T}_{\mathrm{j}}$ ) $\qquad$ $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| :---: |
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|  |  |


| PACKAGE TYPE | $\boldsymbol{\Theta}_{14}($ Note 2) | $\theta_{\text {IC }}$ | UNITS |
| :---: | :---: | :---: | :---: |
| TO-99 (J) | 150 | 18 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin Hermetic DIP (Z) | 148 | 16 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin Plastic DIP (P) | 103 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin SO (S) | 158 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTES:

1. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.:
2. $\theta_{J A}$ is specified for worst case mounting conditions, i.e., $\Theta_{J A}$ is specified for device in socket for TO, CerDIP and P-DIP packages; $\boldsymbol{\theta}_{\text {IA }}$ is specified for device soldered to printed circuit board for SO package.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 2.5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.

|  |  |  | OP-221A/E |  |  | OP-221B |  |  | OP-221C/G |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | UNITS |
| Input Offset Voltage | $\mathrm{V}_{\text {OS }}$ |  | - | 75 | 150 | - | 150 | 300 | - | 250 | 500 | $\mu \mathrm{V}$ |
| Input Offset Current | $\mathrm{l}_{0}$ | $V_{C M}=0$ | - | 0.5 | 3 | - | 1 | 5 | - | 1.5 | 7 | nA |
| Input Bias Current | $I_{B}$ | $V_{C M}=0$ | - | 50 | 80 | - | 60 | 100 | - | 70 | 120 | $n A$ |
| Input Voltage Range | IVR | $\begin{aligned} & \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V} \end{aligned}$ | $\begin{array}{r} 0 / 3.5 \\ -15 / 13.5 \\ \hline \end{array}$ | - | - | $\begin{array}{r} 0 / 3.5 \\ -15 / 13.5 \end{array}$ | - | - | $\begin{array}{r} 0 / 3.5 \\ -15 / 13.5 \end{array}$ | - | - | V |
| Common-Mode Rejection Ratio | CMRR | $\begin{aligned} & \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V} \\ & 0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CM}} \leq 3.5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V} \\ & -15 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CM}} \leq 13.5 \mathrm{~V} \end{aligned}$ | 90 95 | $\begin{aligned} & 100 \\ & 100 \end{aligned}$ | - | 85 90 | 90 95 | - | 75 80 | 85 90 | - - | dB |
| Power Supply <br> Rejection Ratio | PSRR | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}= \pm 2.5 \mathrm{~V} \text { to } \pm 15 \mathrm{~V} \\ & \mathrm{~V}-=0 \mathrm{~V}, \mathrm{~V}+=5 \mathrm{~V} \text { to } 30 \mathrm{~V} \end{aligned}$ | - | 3 6 | $\begin{aligned} & 10 \\ & 18 \end{aligned}$ | - | 10 18 | 32 57 | - | $\begin{aligned} & 32 \\ & 57 \end{aligned}$ | $\begin{aligned} & 100 \\ & 180 \end{aligned}$ | $\mu \mathrm{V} / \mathrm{V}$ |
| Large-Signal Voltage Gain | $A_{\text {vo }}$ | $\begin{aligned} & V_{S}= \pm 15 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \\ & \mathrm{~V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \end{aligned}$ | 1500 | - | - | 1000 | - | - | 800 | - | - | V/mV |
| Output Voltage Swing | $V_{0}$ | $\begin{aligned} & \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \end{aligned}$ | $\begin{gathered} 0.7 / 4.1 \\ \pm 13.8 \end{gathered}$ | - | - | $\begin{gathered} 0.7 / 4.1 \\ \pm 13.8 \end{gathered}$ | - | - | $0.8 / 4$ $\pm 13.5$ | - | - | V |
| Slew Rate | SR | $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$, (Note 1) | 0.2 | 0.3 | - | 0.2 | 0.3 | - | 0.2 | 0.3 | - | $\mathrm{V} / \mu \mathrm{s}$ |
| Bandwidth | BW |  | - | 600 | - | - | 600 | - | - | 600 | - | kHz |
| Supply Current (Both Amplifiers) | $\mathrm{I}_{\text {SY }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}= \pm 2.5 \mathrm{~V}, \text { No Load } \\ & \mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \text { No Load } \end{aligned}$ | - | 450 600 | 550 <br> 800 | - | 500 800 | 600 <br> 850 | - | 550 850 | $\begin{aligned} & 650 \\ & 900 \end{aligned}$ | $\mu \mathrm{A}$ |

## NOTES:

1. Sample tested.
2. Guaranteed by CMRR test limits.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 2.5 \mathrm{~V}$ to $\pm 15 \mathrm{~V},-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ for $\mathrm{OP}-221 \mathrm{~A}, \mathrm{~B}$, and $\mathrm{C},-25^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ for OP-221E, $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ for OP-221G, unless otherwise noted.

|  |  |  | OP-221A/E |  |  | OP-221B |  |  | OP-221C/G |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | UNITS |
| Average Input Offset Voltage Drift (Note 1) | $\mathrm{TCV}_{\text {os }}$ |  | - | 0.75 | 1.5 | - | 1.2 | 2 | - | 2 | 3 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Voltage | $\mathrm{V}_{\mathrm{OS}}$ |  | - | 150 | 300 | - | 250 | 450 | - | 400 | 700 | $\mu \mathrm{V}$ |
| Input Offset Current | los | $\mathrm{V}_{\mathrm{CM}}=0$ | - | 1 | 5 | - | 1.5 | 7 | - | 2 | 10 | nA |
| Input Bias Current | $I_{B}$ | $V_{C M}=0$ | - | 55 | 100 | - | 65 | 120 | - | 80 | 140 | nA |
| Input Voltage Range | IVR | $\begin{aligned} & \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V} \end{aligned}$ | $\begin{array}{r} 0 / 3.2 \\ -15 / 13.2 \\ \hline \end{array}$ | - | - | $0 / 3.2$ $-15 / 13.2$ | - | - | $\begin{array}{r} 0 / 3.2 \\ -15 / 13.2 \end{array}$ | - | - | V |
| Common-Mode Rejection Ratio | CMRR | $\begin{aligned} & \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V} \\ & \mathrm{OV} \leq \mathrm{V}_{\mathrm{CM}} \leq 3.2 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V} \\ & -15 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CM}} \leq 13.2 \mathrm{~V} \end{aligned}$ | 85 90 | 90 95 | - | 80 85 | 85 90 | - - | 70 75 | 80 85 | - - | dB |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 2.5 \mathrm{~V}$ to $\pm 15 \mathrm{~V},-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ for OP-221A, B, and $\mathrm{C},-25^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ for OP-221E, $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ for OP-221G, unless otherwise noted. (Continued)

| PARAMETER | SYMBOL | CONDITIONS | OP-221A/E |  |  | OP-221B |  |  | OP-221C/G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Power Supply | PSRR | $\mathrm{V}_{S}= \pm 2.5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$ | - | 6 | 18 | - | 18 | 57 | - | 57 | 180 | $\mu \mathrm{V} / \mathrm{V}$ |
| Rejection Ratio |  | $\mathrm{V}-=0 \mathrm{~V}, \mathrm{~V}+=5 \mathrm{~V}$ to 30 V | - | 10 | 32 | - | 32 | 100 | - | 100 | 320 |  |
| Large-Signal Voltage Gain | $A_{\text {vo }}$ | $\begin{aligned} & V_{S}= \pm 15 \mathrm{~V}, R_{\mathrm{L}}=10 \mathrm{k} \Omega \\ & \mathrm{~V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \end{aligned}$ | 1000 | - | - | 800 | - | - | 600 | - | - | V/mV |
| Output Voltage Swing | $\mathrm{V}_{\mathrm{O}}$ | $\begin{aligned} & \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V}, \\ & R_{\mathrm{L}}=10 \mathrm{k} \Omega \Omega \end{aligned}$ | 0.8/3.8 | - | - | 0.8/3.8 | - | - | 0.9/3.7 | - | - | V |
|  |  | $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ | $\pm 13.5$ | $\pm 14$ | - | $\pm 13.5$ | $\pm 14$ | - | $\pm 13.2$ | - | - |  |
| Supply Current (Both Amplifiers) | $\mathrm{I}_{\mathrm{SY}}$ | $V_{S}= \pm 2.5 \mathrm{~V}$, No Load | - | 500 | 650 | - | 550 | 700 | - | 600 | 750 | $\mu \mathrm{A}$ |
|  |  | $V_{S}= \pm 15 \mathrm{~V}$, No Load | - | 700 | 900 | - | 900 | 950 | - | 950 | 1000 |  |

## NOTES:

1. Sample tested.
2. Guaranteed by CMRR test limits.

MATCHING CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.

|  |  |  | OP-221A/E |  |  | OP-221B |  |  | OP-221C/G |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | UNITS |
| Input Offset Voltage Match | $\Delta \mathrm{V}_{\text {OS }}$ |  | - | 50 | 200 | - | 150 | 400 | - | 250 | 600 | $\mu \mathrm{V}$ |
| Average Noninverting Bias Current | $\mathrm{I}_{\mathrm{B}}+$ |  | - | - | 80 | - | - | 100 | - | - | 120 | nA |
| Noninverting Input Offset Current | ${ }^{\text {O }}{ }^{+}$ |  | - | 2 | 5 | - | 2 | 5 | - | 4 | 10 | nA |
| Common-Mode Rejection Ratio Match (Note 1) | $\Delta \mathrm{CMRR}$ | $\mathrm{V}_{\mathrm{CM}}=-15 \mathrm{~V}$ to +13.5 V | 92 | - | - | 87 | - | - | 72 | - | - | dB |
| Power Supply Rejection Ratio Match (Note 2) | $\triangle \mathrm{PSRR}$ | $\mathrm{V}_{S}= \pm 2.5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$ | - | - | 14 | - | - | 44 | - | - | 140 | $\mu \mathrm{V} / \mathrm{V}$ |

MATCHING CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V},-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ for OP-221A, B , and $\mathrm{C},-25^{\circ} \mathrm{C} \leq \mathrm{T}_{A} \leq+85^{\circ} \mathrm{C}$ for OP$221 \mathrm{E},-40^{\circ} \mathrm{C} \leq T_{A} \leq+85^{\circ} \mathrm{C}$ for $\mathrm{OP}-221 \mathrm{G}$, unless otherwise noted. Grades E and G are sample tested.

| PARAMETER | SYMBOL | CONDITIONS | OP-221A/E |  |  | OP-221B |  |  | OP-221C/G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Input Offset Voltage Match | $\Delta V_{\text {os }}$ |  | - | 100 | 400 | - | 250 | 600 | - | 400 | 800 | $\mu \mathrm{V}$ |
| Average Noninverting Bias Current | $\mathrm{I}_{\mathrm{B}}+$ | $\mathrm{V}_{\mathrm{CM}}=0$ | - | - | 100 | - | - | 120 | - | - | 140 | nA |
| Input Offset Voltage Tracking | TC $\mathrm{V}_{\text {os }}$ |  | - | 1 | 2 | - | 1 | 3 | - | 3 | 5 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Noninverting Input Offset Current | ${ }^{\prime} \mathrm{os}^{+}$ | $V_{C M}=0$ | - | 3 | 7 | - | 3 | 7 | - | 6 | 12 | nA |
| Common-Mode Rejection Ratio Match (Note 1) | $\Delta \mathrm{CMRR}$ | $\mathrm{V}_{C M}=-15 \mathrm{~V}$ to +13.2 V | 87 | 90 | - | 82 | 85 | - | 72 | 80 | - | dB |
| Power Supply Rejection Ratio Match (Note 2) | $\triangle$ PSRR |  | - | - | 26 | - | - | 78 | - | - | 250 | $\mu \mathrm{V} / \mathrm{V}$ |

## NOTES:

1. $\triangle C M R R$ is $20 \log _{10} V_{C M} / \Delta C M E$, where $V_{C M}$ is the voltage applied to both noninverting inputs and $\triangle C M E$ is the difference in common-mode inputreferred error.
2. $\triangle P S R R$ is: Input-Referred Differential Error
$\Delta \mathrm{V}_{\mathrm{s}}$

# Dual, Precision JFET High Speed Operational Amplifier 

## FEATURES

- Fast Slew Rate $\qquad$ 22V/ $\mu \mathrm{s}$ Typ
- Settling Time (0.01\%) . $1.2 \mu \mathrm{~s}$ Max
- Offset Voltage $.300 \mu \mathrm{~V}$ Max
- High Open-Loop Gain $\qquad$ 1000V/mV Min
- Low Total Harmonic Distortion 0.002\% Typ
- Improved Replacement for AD712, LT1057, OP-215, TLO72, and MC34082
- Available in Die Form


## APPLICATIONS

- Output Amplifier for Fast D/As
- Signal Processing
- Instrumentation Amplifiers
- Fast Sample/Holds
- Active Filters
- Low Distortion Audio Amplifiers
- Input Buffer for A/D Converters
- Servo Controllers


## GENERAL DESCRIPTION

The OP-249 is a high-speed, precision dual JFET op amp, similar to the popular single op amp, the OP-42. The OP-249 outperforms available dual amplifiers by providing superior speed with excellent DC performance. Ultra-high open-loop gain ( $1 \mathrm{kV} / \mathrm{mV}$ minimum), low offset voltage, and superb gain linearity, makes the OP-249 the industry's first true precision, dual high-speed amplifier.
With a slew rate of $22 \mathrm{~V} / \mu$ s typical, and a fast settling time of less than $1.2 \mu \mathrm{~s}$ maximum to $0.01 \%$, the OP- 249 is an ideal choice for high-speed bipolar D/A and A/D converter applications. The excellent DC performance of the OP-249 allows the full accuracy of high-resolution CMOS D/As to be realized.

Symmetrical slew rate, even when driving large loads, such as $600 \Omega$, or 200 pF of capacitance, and ultra-low distortion, make the OP-249 ideal for professional audio applications, active filters, high-speed integrators, servo systems, and buffer amplifiers.
The OP-249 provides significant performance upgrades to the TL072, AD712, OP-215, MC34082 and the LT1057.

## PIN CONNECTIONS




TO-99 (J-Suffix)


FAST SETTLING (0.01\%)



EXCELLENT OUTPUT DRIVE
$R_{L}=600 \Omega$

ORDERING INFORMATION ${ }^{\dagger}$

| PACKAGE |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
|  | CERDIP | PLASTIC | LCC | OPERATING <br> TEMPERATURE |
| TO-99 | 8-PIN | 8-PIN | 20-CONTACT | RANGE |
| OP249AJ* | OP249AZ* $^{*}$ | - | OP249ARC/883 | MIL |
| OP249EJ | - | - | - | XIND |
| OP249FJ | OP249FZ | - | - | XIND |
| - | - | OP249GP | - | XIND |
| - | - | OP249GS ${ }^{\dagger \dagger}$ | - | XIND |

* For devices processed in total compliance to MIL-STD-883, add/883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages. For ordering information, see PMI's Data Book, Section 2.
tt For availability and burn-in information on SO and PLCC packages, contact your local sales office.


## ABSOLUTE MAXIMUM RATINGS (Note 1)

Supply Voltage ..... $\pm 18 \mathrm{~V}$
Input Voltage (Note 2) ..... $\pm 18 \mathrm{~V}$
Differential Input Voltage (Note 2) ..... 36 V
Output Short-Circuit Duration ..... Indefinite

Operating Temperature Range

| OP-249A (J, Z, R |  |  | $125^{\circ} \mathrm{C}$ |
| :---: | :---: | :---: | :---: |
| OP-249E,F (J, Z) | .......... | . | $+85^{\circ} \mathrm{C}$ |
| OP-249G (P, S) . | ......... | - | $+85^{\circ} \mathrm{C}$ |
| Junction Temperat |  |  |  |
| OP-249 (J, Z, RC) | ........... | - | $175{ }^{\circ} \mathrm{C}$ |
| OP-249 (P, S).. |  | - | $150^{\circ} \mathrm{C}$ |
| Lead Temperature | oldering |  | $300^{\circ} \mathrm{C}$ |
| PACKAGE TYPE | $\Theta_{\text {j }}($ Note 3) | $\Theta_{\text {jc }}$ | UNITS |
| TO-99 (J) | 145 | 16 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin Hermetic DIP (Z) | 134 | 12 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8 -Pin Plastic DIP (P) | 96 | 37 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 20-Contact LCC (RC) | 88 | 33 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8 -Pin SO (S) | 150 | 41 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

NOTES:

1. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
2. For supply voltages less than $\pm 18 \mathrm{~V}$, the absolute maximum input voltage is equal to the supply voltage.
3. $\Theta_{j A}$ is specified for worst case mounting conditions, i.e., $\Theta_{i A}$ is specified for device in socket for TO, CerDIP, P-DIP, and LCC packages; $\Theta_{j A}$ is specified for device soldered to printed circuit board for SO package.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-249A |  |  | OP-249E |  |  | OP-249F |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Offset Voltage | $\mathrm{v}_{\text {OS }}$ |  | - | 0.2 | 0.5 | - | 0.1 | 0.3 | - | 0.2 | 0.7 | mV |
| Long Term Offset Voltage | $\mathrm{v}_{\text {os }}$ | (Note 1) | - | - | 0.8 | - | - | 0.6 | - | - | 1.0 | mV |
| Offset Stability |  |  | - | 1.5 | - | - | 1.5 | - | - | 1.5 |  | V/Month |
| Input Bias Current | $I_{B}$ | $V_{C M}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{j}}=+25^{\circ} \mathrm{C}$ | - | 30 | 75 | - | 20 | 50 | - | 30 | 75 | pA |
| Input Offset Current | Ios | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{j}}=+25^{\circ} \mathrm{C}$ | - | 6 | 25 | - | 4 | 15 | - | 6 | 25 | pA |
| Input Voltage Range | IVR | (Note 2) | $\pm 11$ | $\begin{aligned} & +12.5 \\ & -12.5 \end{aligned}$ | - | $\pm 11$ | $\begin{aligned} & +12.5 \\ & -12.5 \end{aligned}$ | - | $\pm 11$ | $\begin{array}{r} +12.5 \\ -12.5 \end{array}$ | - | V |
| Common-Mode Rejection | CMR | $\mathrm{V}_{C M}= \pm 11 \mathrm{~V}$ | 80 | 90 | - | 86 | 95 | - | 80 | 90 | - | dB |
| Power-Supply <br> Rejection Ratio | PSRR | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}= \pm 4.5 \mathrm{~V} \\ & \text { to } \pm 18 \mathrm{~V} \end{aligned}$ | - | 12 | 31.6 | - | 9 | 31.6 | - | 12 | 50 | $\mu \mathrm{V} / \mathrm{V}$ |
| Large-Signal Voltage Gain | $A_{\text {vo }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \end{aligned}$ | 1000 | 1400 | - | 1000 | 1400 | - | 500 | 1200 | - | V/mV |
| Output Voltage Swing | $V_{0}$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | $\pm 12.0$ | $\begin{aligned} & +12.5 \\ & -12.5 \end{aligned}$ | - | $\pm 12.0$ | $\begin{array}{r} +12.5 \\ -12.5 \end{array}$ | - | $\pm 12.0$ | $\begin{aligned} & +12.5 \\ & -12.5 \end{aligned}$ | - | V |
| Short-Circuit Current Limit | $\mathrm{I}_{\mathrm{sc}}$ | Output Shorted to Ground | $\pm 20$ | $\begin{aligned} & +36 \\ & -33 \end{aligned}$ | $\pm 50$ | $\pm 20$ | $\begin{aligned} & +36 \\ & -33 \end{aligned}$ | $\pm 50$ | $\pm 20$ | $\begin{aligned} & +36 \\ & -33 \end{aligned}$ | $\pm 50$ | mA |
| Supply Current | $I_{\text {SY }}$ | No Load $v_{\mathrm{O}}=0 \mathrm{~V}$ | - | 5.6 | 7.0 | - | 5.6 | 7.0 | - | 5.6 | 7.0 | mA |
| Slew Rate | SR | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ | 18 | 22 | - | 18 | 22 | - | 18 | 22 | - | $\mathrm{V} / \mathrm{\mu s}$ |
| Gain-Bandwidth Product | GBW | (Note 4) | 3.5 | 4.7 | - | 3.5 | 4.7 | - | 3.5 | 4.7 | - | MHz |
| Settling Time | $t_{s}$ | 10V Step 0.01\% <br> (Note 3) | - | 0.9 | 1.2 | - | 0.9 | 1.2 | - | 0.9 | 1.2 | $\mu \mathrm{s}$ |
| Phase Margin | $\Theta_{0}$ | OdB Gain | - | 55 | - | - | 55 | - | - | 55 | - | Deg |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted. Continued

| PARAMETER | SYMBOL | CONDITIONS | min $_{\text {OP-249A }}^{\text {TYP }}$ ( max |  |  | OP-249E |  |  | OP-249F |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Parameter | SYMBOL | CONDITIONS |  |  | MAX |  |  | MAX | MIN |  | MAX | UNITS |
| Differential Input Impedance | $z_{\text {IN }}$ |  | - $10^{12}\| \| 6$ |  | - | - $10^{12}\| \| 6$ |  | - | - $10^{12}\| \| 6$ |  | - | $\boldsymbol{\Omega} \\|$ PF |
| Open-Loop Output Resistance | $\mathrm{R}_{0}$ | 0.1 Hz to 10 Hz | - | 35 | - | - | 35 | - | - | 35 | - | $\Omega$ |
| Voltage Noise | $e_{n \text { p-p }}$ |  | - | 2 | - | - | 2 | - | - | 2 | - | $\mu \mathrm{V}_{\mathrm{p}-\mathrm{p}}$ |
|  | ${ }^{\boldsymbol{n}}$ | $\begin{aligned} & \mathrm{f}_{\mathrm{O}}=10 \mathrm{~Hz} \\ & \mathrm{f}_{\mathrm{O}}=100 \mathrm{~Hz} \\ & \mathrm{f}_{\mathrm{O}}=1 \mathrm{kHz} \\ & \mathrm{f}_{\mathrm{O}}=10 \mathrm{kHz} \end{aligned}$ | - | 75 | - | - | 75 | - | - | 75 | - |  |
| Voltage Noise |  |  | - | 26 | - | - | 26 | - | - | 26 | - | $\mathrm{V} / \sqrt{\mathrm{Hz}}$ |
| Density |  |  | - | 17 | - | - | 17 | - | - | 17 | - | $\mathrm{nV} \sqrt{\mathrm{Hz}}$ |
|  |  |  | - | 16 | - | - | 16 | - | - | 16 | - |  |
| Current Noise Density | $i_{n}$ | $\mathrm{f}_{\mathrm{o}}=1 \mathrm{kHz}$ | - | 0.003 | - | - | 0.003 | - | - | 0.003 | - | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
| Voltage Supply Range | $v_{s}$ |  | $\pm 4.5$ | $\pm 15$ | $\pm 18$ | $\pm 4.5$ | $\pm 15$ | $\pm 18$ | $\pm 4.5$ | $\pm 15$ | $\pm 18$ | v |

$\begin{array}{ll}\text { NOTES: } & \text { 2. Guaranteed by CMR test. } \\ 1 \text { Long term offset voltage is guaranteed by a } 1000 \text { HR life test performed on } 3 & \text { 3. Settling-time is sample tes }\end{array}$

Long term offset voitage is guaranteed by a 1000 HR
independent wafer lots at $+125^{\circ} \mathrm{C}$ with a LTPD of 3 .
3. Settling-time is sample tested.
4. Guaranteed by design.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | MIN | OP-249G <br> TYP | MAX |
| :--- | :--- | :--- | :--- | ---: | :--- | UNITS

## NOTES:

1. Guaranteed by CMR test.
2. Guaranteed by design.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted. Continued

| PARAMETER | SYMBOL | CONDITIONS |  | MIN | OP-249G <br> TYP | MAX |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | UNITS

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ for $\mathrm{E} / \mathrm{F}$ grades, and $-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ for A grade, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-249A |  |  | OP-249E |  |  | OP-249F |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Offset Voltage | $\mathrm{V}_{\text {OS }}$ |  | - | 0.12 | 1.0 | - | 0.1 | 0.5 | - | 0.5 | 1.1 | mV |
| Offset Voltage Temperature Coefficient | $\mathrm{TCV}_{\text {os }}$ |  | - | 1 | 5 | - | 1 | 3 | - | 1.2 | 6 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Bias Current | $I_{B}$ | (Note 1) | - | 4 | 20 | - | 0.25 | 3.0 | - | 0.3 | 4.0 | nA |
| Input Offset Current | Ios | (Note 1) | - | 0.04 | 4 | - | 0.01 | 0.7 | - | 0.02 | 1.2 | $n \mathrm{~A}$ |
| Input Voltage Range | IVR | (Note 2) | $\pm 11$ | $\begin{array}{r} +12.5 \\ -12.5 \end{array}$ | - | $\pm 11$ | $\begin{aligned} & +12.5 \\ & -12.5 \end{aligned}$ | - | $\pm 11$ | $\begin{aligned} & +12.5 \\ & -12.5 \end{aligned}$ | - | V |
| Common-Mode Rejection | CMR | $\mathrm{V}_{\mathrm{CM}}= \pm 11 \mathrm{~V}$ | 76 | 110 | - | 86 | 100 | - | 76 | 95 | - | dB |
| Power-Supply <br> Rejection Ratio | PSRR | $\begin{aligned} & V_{S}= \pm 4.5 \mathrm{~V} \\ & \text { to } \pm 18 \mathrm{~V} \end{aligned}$ | - | 5 | 50 | - | 5 | 50 | - | 7 | 100 | $\mu \mathrm{V} / \mathrm{V}$ |
| Large-Signal Voltage Gain | $A_{\text {vo }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & \mathrm{~V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \end{aligned}$ | 500 | 1400 | - | 750 | 1400 | - | 250 | 1200 | - | $\mathrm{V} / \mathrm{mV}$ |
| Output Voltage Swing | $V_{0}$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | $\pm 12.0$ | $\begin{array}{r} +12.5 \\ -12.5 \end{array}$ | - | $\pm 12.0$ | $\begin{array}{r} +12.5 \\ -12.5 \end{array}$ | - | $\pm 12.0$ | $\begin{aligned} & +12.5 \\ & -12.5 \end{aligned}$ | - | V |
| Short-Circuit Current Limit | $I_{\text {Sc }}$ | Output Shorted to Ground | $\pm 10$ | - | $\pm 60$ | $\pm 18$ | - | $\pm 60$ | $\pm 18$ | - | $\pm 60$ | mA |
| Supply Current | $I_{\text {SY }}$ | No Load $v_{\mathrm{O}}=0 \mathrm{~V}$ | - | 5.6 | 7.0 | - | 5.6 | 7.0 | - | 5.6 | 7.0 | mA |

## NOTES:

1. $T_{j}=85^{\circ} \mathrm{C}$ for $\mathrm{E} / \mathrm{F}$ Grades; $\mathrm{T}_{\mathrm{j}}=125^{\circ} \mathrm{C}$ for A Grade.
2. Guaranteed by CMR test.

ELECTRICAL CHARACTERISTICS at $V_{S}= \pm 15 \mathrm{~V},-40^{\circ} \mathrm{C} \leq T_{A} \leq+85^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | MIN | $\underset{\substack{\text { TYP }}}{\text { OP-249G }}$ | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Offset Voltage | $v_{\text {os }}$ |  | - | 1.0 | 3.6 | mV |
| Offset Voltage Temperature Coefficient | TCV ${ }_{\text {Os }}$ |  | - | 6 | 25 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Bias Current | $I_{B}$ | (Note 1) | - | 0.5 | 4.5 | nA |
| Input Offset Current | Ios | (Note 1) | - | 0.04 | 1.5 | nA |
| Input Voltage Range | IVR | (Note 2) | $\pm 11.0$ | $\begin{aligned} & +12.5 \\ & -12.5 \end{aligned}$ | - | V |
| Common-Mode Rejection | CMR | $\mathrm{V}_{\mathrm{CM}}= \pm 11 \mathrm{~V}$ | 76 | 95 | - | dB |
| Power-Supply Rejection Ratio | PSRR | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}= \pm 4.5 \mathrm{~V} \\ & \text { to } \pm 18 \mathrm{~V} \end{aligned}$ | - | 10.0 | 100 | $\mu \mathrm{V} / \mathrm{N}$ |
| Large-Signal Voltage Gain | $A_{\text {vo }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & \mathrm{~V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \end{aligned}$ | 250 | 1200 | - | V/mV |
| Output Voltage Swing | $V_{0}$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | $\pm 12.0$ | $\begin{array}{r} +12.5 \\ -12.5 \end{array}$ | - | V |
| Short-Circuit Current Limit | $I_{\text {sc }}$ | Output Shorted to Ground | $\pm 18$ | - | $\pm 60$ | mA |
| Supply Current | $\mathrm{I}_{\mathrm{SY}}$ | No Load $\mathrm{V}_{\mathrm{O}}=0 \mathrm{~V}$ | - | 5.6 | 7.0 | mA |

## NOTES:

1. $\mathrm{T}_{\mathrm{i}}=85^{\circ} \mathrm{C}$.
2. Guaranteed by CMR test.

## FEATURES

- Very Low Noise
- Excellent Input Offset Voltage

5nV/ $\sqrt{\mathrm{Hz}}$ @ 1 kHz Max
....... 75 $\mu$ V Max

- Very High Gain . . . . . . . . . . . . . . . . . . . . . . . . . . 1500V/mV Min
- Outstanding CMR . . . . . . . . . . . . . . . . . . . . . . . . . . . 106dB Min
- Slew Rate . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 2.4V/ $\mu$ s Typ
- Gain-Bandwidth Product . . . . . . . . . . . . . . . . . . . . 5MHz Typ
- Industry Standard 8-Pin Dual Pinout
- Available in Die Form


## ORDERING INFORMATION ${ }^{\dagger}$

| $\begin{gathered} T_{A}=+25^{\circ} \mathrm{C} \\ \hat{V}_{\mathrm{OS}}{ }_{(\mu \mathrm{V})} \\ \hline \end{gathered}$ | PACKAGE |  |  | OPERATING TEMPERATURE RANGE |
| :---: | :---: | :---: | :---: | :---: |
|  | $\begin{aligned} & \text { CERDIP } \\ & 8 \text {-PIN } \end{aligned}$ | PLASTIC | $\frac{\text { LCC }}{20 \text {-CONTACT }}$ |  |
| 75 | OP270AZ* | - | OP270ARC/883 | MIL |
| 75 | OP270EZ | - | - | XIND |
| 150 | OP270FZ | - | - | XIND |
| 250 | - | OP270GP | - | XIND |
| 250 | - | OP270Gs ${ }^{\text {H }}$ | - | XIND |

- For devices processed in total compliance to MIL-STD-883, add /883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.
$\dagger \dagger$ For availability and burn-in information on SO and PLCC packages, contact you local sales office.


## GENERAL DESCRIPTION

The OP-270 is a high-performance monolithic dual operational amplifier with exceptionally low voltage noise,

## PIN CONNECTIONS


$5 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ at 1 kHz Max, offering comparable performance to PMI's industry standard OP-27.
The OP-270 features an input offset voltage below $75 \mu \mathrm{~V}$ and an offset drift under $1 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$, guaranteed over the full military temperature range. Open-loop gain of the OP-270 is over $1,500,000$ into a $10 \mathrm{k} \Omega$ load insuring excellent gain accuracy and linearity, even in high-gain applications. Input bias current is under 20nA which reduces errors due to signal source resistance. The OP-270's CMR of over 106dB and PSRR of less than $3.2 \mu \mathrm{~V} / \mathrm{V}$ significantly reduce errors due to


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ground noise and power supply fluctuations. Power consumption of the dual OP-270 is one-third less than two OP-27s, a significant advantage for power conscious applications. The OP-270 is unity-gain stable with a gainbandwidth product of 5 MHz and a slew rate of $2.4 \mathrm{~V} / \mu \mathrm{s}$.

The OP-270 offers excellent amplifier matching which is important for applications such as multiple gain blocks, lownoise instrumentation amplifiers, dual buffers, and low-noise active filters.

The OP-270 conforms to the industry standard 8-pin DIP pinout. It is pin compatible with the MC1458/1558, SE5532/A, RM4558 and HA5102 dual op amps and can be used to upgrade systems using these devices.
For higher speed applications the OP-271, with a slew rate of $8 \mathrm{~V} / \mu \mathrm{s}$, is recommended. For a quad op amp, see the OP-470.

## ABSOLUTE MAXIMUM RATINGS (Note 1)

Supply Voltage
Differential Input Voltage (Note 2) ................................... $\pm 1.0 \mathrm{~V}$
Differential Input Current (Note 2) ................................ $\pm 25 \mathrm{~mA}$
Input Voltage ................................................ Supply Voltage
Output Short-Circuit Duration ................................ Continuous

Storage Temperature Range
P, RC, S, Z-Package $\qquad$ $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ Lead Temperature Range (Soldering, 60 sec ) $\qquad$ $300^{\circ} \mathrm{C}$ Junction Temperature ( $\mathrm{T}_{\text {}}$ ) $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ Operating Temperature Range
OP-270A $\ldots . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . ~$
OP- $55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
$-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
OP-270E, OP-270F, OP-270G .................... $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$

| PACKAGE TYPE | $\theta_{\text {ja }}$ (Note 3) | $\theta_{\text {Jc }}$ | UNITS |
| :---: | :---: | :---: | :---: |
| 8-Pin Hermetic DIP (Z) | 134 | 12 | ${ }^{\circ} \mathrm{C} / \mathrm{N}$ |
| 8-Pin Plastic DIP (P) | 96 | 37 | ${ }^{\circ} \mathrm{CN}$ |
| 20-Contact LCC (RC) | 88 | 33 | ${ }^{\circ} \mathrm{C} / \mathrm{N}$ |
| 16-Pin SOL (S) | 92 | 27 | ${ }^{\circ} \mathrm{C} / \mathrm{N}$ |

NOTES:

1. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
2. The OP-270's inputs are protected by back-to-back diodes. Current limiting resistors are not used in order to achieve low noise performance. If differential voltage exceeds $\pm 10 \mathrm{~V}$, the input current should be limited to $\pm 25 \mathrm{~mA}$.
3. $\Theta_{j A}$ is specified for worst case mounting conditions, i.e., $\Theta_{j A}$ is specified for device in socket for CerDIP, P-DIP, and LCC packages; $\Theta_{j}$ is specified for device soldered to printed circuit board for SOL package.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.

|  |  |  | OP-270A/E |  |  | OP-270F |  |  | OP-270G |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | UNITS |
| Input Offset Voltage | $V_{\text {os }}$ | - | - | 10 | 75 | - | 20 | 150 | - | 50 | 250 | $\mu \mathrm{V}$ |
| Input Offset Current | Ios | $V_{C M}=O V$ | - | 1 | 10 | - | 3 | 15 | - | 5 | 20 | nA |
| Input Bias Current | $I_{B}$ | $\mathrm{V}_{\mathrm{CM}}=\mathrm{OV}$ | - | 5 | 20 | - | 10 | 40 | - | 15 | 60 | nA |
| Input Noise Voltage | $e_{n \text { p-p }}$ | 0.1 Hz to 10 Hz (Note 1) | - | 80 | 200 | - | 80 | 200 | - | 80 | - | nVp-p |
| Input Noise Voltage Density | $e_{n}$ | $\begin{aligned} & \mathrm{f}_{\mathrm{O}}=10 \mathrm{~Hz} \\ & \mathrm{f}_{\mathrm{O}}=100 \mathrm{~Hz} \\ & \mathrm{f}_{0}=1 \mathrm{kHz} \\ & \text { (Note 2) } \end{aligned}$ | - | $\begin{aligned} & 3.6 \\ & 3.2 \\ & 3.2 \end{aligned}$ | $\begin{aligned} & 6.5 \\ & 5.5 \\ & 5.0 \end{aligned}$ | - | $\begin{aligned} & 3.6 \\ & 3.2 \\ & 3.2 \end{aligned}$ | $\begin{aligned} & 6.5 \\ & 5.5 \\ & 5.0 \end{aligned}$ | - | $\begin{aligned} & 3.6 \\ & 3.2 \\ & 3.2 \end{aligned}$ | - | $n \mathrm{~V} / \sqrt{\mathrm{Hz}}$ |
| Input Noise Current Density | $i_{n}$ | $\begin{aligned} & \mathrm{f}_{\mathrm{O}}=10 \mathrm{~Hz} \\ & \mathrm{f}_{\mathrm{O}}=100 \mathrm{~Hz} \\ & \mathrm{f}_{\mathrm{O}}=1 \mathrm{kHz} \end{aligned}$ | - | $\begin{aligned} & 1.1 \\ & 0.7 \\ & 0.6 \end{aligned}$ | - | - | $\begin{aligned} & 1.1 \\ & 0.7 \\ & 0.6 \end{aligned}$ | - | - | $\begin{aligned} & 1.1 \\ & 0.7 \\ & 0.6 \end{aligned}$ | - | $\mathrm{pA} \sqrt{\mathrm{Hz}}$ |
| Large-Signal Voltage Gain | $A_{\text {vo }}$ | $\begin{aligned} & V_{O}= \pm 10 \mathrm{~V} \\ & R_{L}=10 \mathrm{k} \Omega \\ & R_{L}=2 \mathrm{k} \Omega \end{aligned}$ | $\begin{array}{r} 1500 \\ 750 \end{array}$ | $\begin{aligned} & 2300 \\ & 1200 \end{aligned}$ | - | $\begin{array}{r} 1000 \\ 500 \end{array}$ | $\begin{array}{r} 1700 \\ 900 \end{array}$ | - | $\begin{aligned} & 750 \\ & 350 \end{aligned}$ | $\begin{array}{r} 1500 \\ 700 \end{array}$ | - | $\mathrm{V} / \mathrm{mV}$ |
| Input Voltage Range | IVR | (Note 3) | $\pm 12$ | $\pm 12.5$ | - | $\pm 12$ | $\pm 12.5$ | - | $\pm 12$ | $\pm 12.5$ | - | V |
| Output Voltage Swing | $\mathrm{V}_{0}$ | $\mathrm{R}_{\mathrm{L}} \geq 2 \mathrm{k} \Omega$ | $\pm 12$ | $\pm 13.5$ | - | $\pm 12$ | $\pm 13.5$ | - | $\pm 12$ | $\pm 13.5$ | - | V |
| Common-Mode Rejection | CMR | $\mathrm{V}_{C M}= \pm 11 \mathrm{~V}$ | 106 | 125 | - | 100 | 120 | - | 90 | 110 | - | dB |
| Power Supply Rejection Ratio | PSRR | $V_{S}= \pm 4.5 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | 0.56 | 3.2 | - | 1.0 | 5.6 | - | 1.5 | 6 | $\mu \mathrm{V} / \mathrm{V}$ |
| Slew Rate | SR |  | 1.7 | 2.4 | - | 1.7 | 2.4 | - | 1.7 | 2.4 | - | $\mathrm{V} / \mathrm{\mu s}$ |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted. Continued

|  |  |  | OP-270A/E |  |  | OP-270F |  |  | OP-270G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Supply Current <br> (All Amplifiers) | $\mathrm{I}_{\text {SY }}$ | No Load | - | 4 | 6.5 | - | 4 | 6.5 | - | 4 | 6.5 | mA |
| Gain Bandwidth Product | GBW |  | - | 5 | - | - | 5 | - | - | 5 | - | MHz |
| Channel Separation | CS | $\begin{aligned} & V_{\mathrm{O}}=20 V_{\mathrm{p}-\mathrm{p}} \\ & \mathrm{f}_{\mathrm{O}}=10 \mathrm{~Hz} \text { (Note 1) } \end{aligned}$ | 125 | 175 | - | 125 | 175 | - | - | 175 | - | dB |
| Input Capacitance | $\mathrm{C}_{\text {IN }}$ |  | - | 3 | - | - | 3 | - | - | 3 | - | pF |
| Input Resistance Differential-Mode | $\mathrm{R}_{\text {IN }}$ |  | - | 0.4 | - | - | 0.4 | - | - | 0.4 | - | $\mathrm{M} \Omega$ |
| Input Resistance Common-Mode | $\mathrm{R}_{\text {INCM }}$ |  | - | 20 | - | - | 20 | - | - | 20 | - | G $\Omega$ |
| Settling Time | $t_{\text {s }}$ | $\begin{aligned} & \mathrm{A}_{\mathrm{V}}=+1,10 \mathrm{~V} \text { Step } \\ & \text { to } 0.01 \% \end{aligned}$ | - | 5 | - | - | 5 | - | - | 5 | - | $\mu \mathrm{s}$ |

## NOTES:

1. Guaranteed by not $100 \%$ tested.
2. Sample tested.
3. Guaranteed by CMR test.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V},-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ for OP-270A, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-270A |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | UNITS |
| Input Offset Voltage | $\mathrm{V}_{\text {OS }}$ |  | - | 30 | 175 | $\mu \mathrm{V}$ |
| Average Input Offset Voltage Drift | $\mathrm{TCV}_{\text {os }}$ |  | - | 0.2 | 1 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current | los | $\mathrm{V}_{C M}=0 \mathrm{~V}$ | - | 2 | 30 | nA |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 6 | 60 | $n \mathrm{~A}$ |
| Large-Signal Voltage Gain | Avo | $\begin{aligned} \mathrm{V}_{\mathrm{O}} & = \pm 10 \mathrm{~V} \\ \mathrm{R}_{\mathrm{L}} & =10 \mathrm{k} \Omega \\ \mathrm{R}_{\mathrm{L}} & =2 \mathrm{k} \Omega \end{aligned}$ | 750 400 | 1600 800 | - | V/mV |
| Input Voltage Range | IVR | (Note 1) | $\pm 12$ | $\pm 12.5$ | - | V |
| Output Voltage Swing | $\mathrm{V}_{0}$ | $\mathrm{R}_{\mathrm{L}} \geq 2 \mathrm{k} \Omega$ | $\pm 12$ | $\pm 13$ | - | V |
| Common-Mode Rejection | CMR | $\mathrm{V}_{\mathrm{CM}}= \pm 11 \mathrm{~V}$ | 100 | 120 | - | dB |
| Power Supply <br> Rejection Ration | PSRR | $V_{S}= \pm 4.5 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | 1.0 | 5.6 | $\mu \mathrm{V} / \mathrm{V}$ |
| Supply Current <br> (All Amplifiers) | Isy | No Load | - | 4.5 | 7.5 | mA |

NOTE:

1. Guaranteed by CMR test.

ELECTRICAL CHARACTERISTICS at $V_{S}= \pm 15 \mathrm{~V},-40^{\circ} \mathrm{C} \leq T_{A} \leq+85^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-270E |  |  | OP-270F |  |  | OP-270G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Input Offset Voltage | $\mathrm{V}_{\text {os }}$ |  | - | 25 | 150 | - | 45 | 275 | - | 100 | 400 | $\mu \mathrm{V}$ |
| Average Input Offset Voltage Drift | $\mathrm{TCV}_{\text {os }}$ | , | - | 0.2 | 1 | - | 0.4 | 2 | - | 0.7 | 3 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current | l OS | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 1.5 | 30 | - | 5 | 40 | - | 15 | 50 | nA |
| Input Bias Current | $I_{B}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 6 | 60 | - | 15 | 70 | - | 19 | 80 | nA |
| Large-Signal Voltage Gain | Avo | $\begin{aligned} V_{O} & = \pm 10 \mathrm{~V} \\ R_{L} & =10 \mathrm{k} \Omega \\ R_{L} & =2 \mathrm{k} \Omega \end{aligned}$ | $\begin{array}{r} 1000 \\ 500 \end{array}$ | $\begin{array}{r} 1800 \\ 900 \end{array}$ | - | 600 300 | $\begin{array}{r} 1400 \\ 700 \end{array}$ | - | $\begin{aligned} & 400 \\ & 225 \end{aligned}$ | $\begin{array}{r} 1250 \\ 670 \end{array}$ | - | V/mV |
| Input Voltage Range | IVR | (Note 1) | $\pm 12$ | $\pm 12.5$ | - | $\pm 12$ | $\pm 12.5$ | - | $\pm 12$ | $\pm 12.5$ | - | V |
| Output Voltage Swing | $V_{0}$ | $\mathrm{R}_{\mathrm{L}} \geq 2 \mathrm{k} \boldsymbol{\Omega}$ | $\pm 12$ | $\pm 13$ | - | $\pm 12$ | $\pm 13$ | - | $\pm 12$ | $\pm 13$ | - | V |
| Common-Mode Rejection | CMR | $V_{C M}= \pm 11 \mathrm{~V}$ | 100 | 120 | - | 94 | 115 | - | 90 | 100 | - | dB |
| Power Supply <br> Rejection Ration | PSRR | $V_{S}= \pm 4.5 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | 0.7 | 5.6 | - | 1.8 | 10 | - | 2.0 | 15 | $\mu \mathrm{V} / \mathrm{N}$ |
| Supply Current <br> (All Amplifiers) | Isy | No Load | - | 4.4 | 7.2 | - | 4.4 | 7.2 | - | 4.4 | 7.2 | mA |

## NOTE:

1. Guaranteed by CMR test.

# High Speed, Dual Operational Amplifier 

## FEATURES

- Excellent Speed $\qquad$ $8.5 \mathrm{~V} / \mu \mathrm{s}$ Typ
- Fast Settling (0.01\%) $2 \mu \mathrm{~s}$ Typ
- Unity-Gain Stable
- High Gain-Bandwidth

5MHz Typ

- Low Input Offset Voltage $200 \mu \mathrm{~V}$ Max
- Low Offset Voltage Drift $2 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ Max
- High Gain 400V/mV Min
- Outstanding CMR 106 dB Min
- Industry Standard 8-Pin Dual Pinout
- Available in Die Form

ORDERING INFORMATION ${ }^{\dagger}$

| $\begin{gathered} \mathrm{T}_{A}=+25 \mathrm{C} \\ \mathrm{~V}_{\text {OS }} \text { MAX } \\ (\mu \mathrm{V}) \end{gathered}$ | PACKAGE |  |  | OPERATINGTEMPERATURERANGE |
| :---: | :---: | :---: | :---: | :---: |
|  | CERDIP <br> 8-PIN | PLASTIC | $\begin{gathered} \text { LCC } \\ \text { 20-CONTACT } \end{gathered}$ |  |
| 200 | OP271AZ* | - | OP271ARC/883 | MIL |
| 200 | OP271EZ | - | - | XND |
| 300 | OP271FZ | - | - | XND |
| 400 | - | OP271GP | - | XND |
| 400 | - | OP271GS $\dagger \dagger$ | - | XND |

* For devices processed in total compliance to MIL-STD-883, add /883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.
H For availability and burn-in information on SO and PLCC packages, contact your local sales office.


## GENERAL DESCRIPTION

The OP-271 is a unity-gain stable monolithic dual op amp featuring excellent speed, $8.5 \mathrm{~V} / \mu$ s typical, and fast settling time, $2 \mu \mathrm{~s}$ typical to $0.01 \%$. The OP-271 has a gain-bandwidth of 5 MHz with a high phase margin of $62^{\circ}$.

Input offset voltage of the OP-271 is under $200 \mu \mathrm{~V}$ with input offset voltage drift below $2 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$, guaranteed over the full military temperature range. Open-loop gain exceeds 400,000 into a $10 \mathrm{k} \Omega$ load ensuring outstanding gain accuracy and linearity. The input bias current is under 20 nA limiting errors due to source resistance. The OP-271's outstanding CMR, over 106dB, and low PSRR, under $5.6 \mu \mathrm{~V} / \mathrm{V}$, reduce errors caused by ground noise and power supply fluctuations. In addition, the OP-271 exhibits high CMR and PSRR over a wide frequency range, further improving system accuracy.

Continued

PIN CONNECTIONS


EPOXY MINI-DIP (P-Suffix)
8-PIN HERMETIC DIP
(Z-Suffix)

SIMPLIFIED SCHEMATIC (One of the two amplifiers is shown.)


This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

The OP-271 offers outstanding DC and AC matching between channels. This is especially valuable for applications such as multiple gain blocks, high-speed instrumentation and amplifiers, buffers and active filters.
The OP-271 conforms to the industry standard 8-pin dual op amp pinout. It is pin compatible with the TL072, TL082, LF412, and 1458/1558 dual op amps and can be used to significantly improve systems using these devices.
For applications requiring lower voltage noise, see the OP270. For a quad version of the OP-271, see the OP-471.

## ABSOLUTE MAXIMUM RATINGS (Note 1)

Supply Voltage
Differential Input Voltage (Note 2)................................... $\pm 1.0 \mathrm{~V}$
Differential Input Current (Note 2) ................................. $\pm 25 \mathrm{~mA}$
Input Voltage .................................................... Supply Voltage
Output Short-Circuit Duration ................................ Continuous
Storage Temperature Range ........................ $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

Lead Temperature (Soldering, 60 sec ) ........................ $+300^{\circ} \mathrm{C}$ Junction Temperature ( $\mathrm{T}_{\mathrm{j}}$ ) .............................. $-65^{\circ} \mathrm{C}$ to +150 C Operating Temperature Range

$$
\text { OP-271A .................................................... }-55^{\circ} \mathrm{C} \text { to }+125^{\circ} \mathrm{C}
$$

OP-271E, OP-271F, OP-271G ...................... $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$

| PACKAGE TYFE | $\boldsymbol{\theta}_{14}$ (Note 3) | $\theta_{\text {jc }}$ | UNITS |
| :---: | :---: | :---: | :---: |
| 8-Pin Hermetic DIP (Z) | 134 | 12 | ${ }^{\circ} \mathrm{C}$ W |
| 8 8-Pin Plastic DIP (P) | 96 | 37 | ${ }^{\circ} \mathrm{CN}$ |
| 20-Contact LCC (RC) | 88 | 33 | ${ }^{\circ} \mathrm{CW}$ |
| 8-Pin SO (S) | 92 | 27 | ${ }^{\circ} \mathrm{CM}$ |

## NOTES:

1. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
2. The OP-271's inputs are protected by back-to-back diodes. Current limiting resistors are not used in order to achieve low noise performance. If differential voltage exceeds $\pm 1.0 \mathrm{~V}$, the input current should be limited to $\pm 25 \mathrm{~mA}$.
3. $\Theta_{\mathrm{iA}}$ is specified for worst case mounting conditions, i.e., $\Theta_{\mathrm{i} A}$ is specified for device in socket for CerDIP, P-DIP, and LCC packages; $\Theta_{j A}{ }^{\mathrm{A}}$ is specified for device soldered to printed circuit board for SOL package.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-271A/E |  |  | OP-271F |  |  | OP-271G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Input Offset Voltage | $V_{\text {os }}$ |  | - | 75 | 200 | - | 150 | 300 | - | 200 | 400 | $\mu \mathrm{V}$ |
| Input Offset Current | los | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 1 | 10 | - | 4 | 15 | - | 7 | 20 | nA |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 4 | 20 | - | 6 | 40 | - | 12 | 60 | nA |
| Input Noise Voltage Density | $\mathrm{e}_{\mathrm{n}}$ | $\mathrm{f}_{\mathrm{O}}=1 \mathrm{kHz}$ | - | 7.6 | - | - | 7.6 | - | - | 7.6 | - | $\mathrm{nV} / \mathrm{Hz}$ |
| Large-Signal Voltage Gain | $A_{\text {vo }}$ | $\begin{aligned} & V_{O}= \pm 10 \mathrm{~V} \\ & R_{L}=10 \mathrm{k} \Omega \\ & R_{L}=2 \mathrm{k} \Omega \\ & \hline \end{aligned}$ |  |  |  |  |  |  |  |  |  |  |
|  |  |  | 400 | 650 | - | 300 | 500 | - | 250 | 400 | - | V/mV |
|  |  |  | 300 | 500 | - | 200 | 300 | - | 175 | 250 | - |  |
| Input Voltage Range | IVR | (Note 1) | $\pm 12$ | $\pm 12.5$ | - | $\pm 12$ | $\pm 12.5$ | - | $\pm 12$ | $\pm 12.5$ | - | V |
| Output Voltage Swing | $\mathrm{V}_{0}$ | $\mathrm{R}_{\mathrm{L}} \geq 2 \mathrm{k} \boldsymbol{\Omega}$ | $\pm 12$ | $\pm 13$ | - | $\pm 12$ | $\pm 13$ | - | $\pm 12$ | $\pm 13$ | - | V |
| Common-Mode Rejection | CMR | $\mathrm{V}_{\mathrm{CM}}= \pm 12 \mathrm{~V}$ | 106 | 120 | - | 100 | 115 | - | 90 | 105 | - | dB |
| Power Supply Rejection Ratio | PSRR | $V_{S}= \pm 4.5 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | 0.6 | 3.2 | - | 1.8 | 5.6 | - | 2.4 | 7.0 | $\mu \mathrm{VN}$ |
| Slew Rate | SR |  | 5.5 | 8.5 | - | 5.5 | 8.5 | - | 5.5 | 8.5 | - | $\mathrm{V} / \mathrm{s} \mathrm{s}$ |
| Phase Margin | $\square_{\text {m }}$ | $A_{V}=+1$ | - | 62 | - | - | 62 | - | - | 62 | - | deg |
| Supply Current (All Amplifiers) | $\mathrm{I}_{\mathrm{s} Y}$ | No Load | - | 4.5 | 6.5 | - | 4.5 | 6.5 | - | 4.5 | 6.5 | mA |
| Gain Bandwidth Product | GBW |  | - | 5 | - | - | 5 | - | - | 5 | - | MHz |
| Channel Separation | CS | $\begin{aligned} & \mathrm{V}_{\mathrm{O}}=20 \mathrm{~V}_{\mathrm{p}-\mathrm{p}} \\ & \mathrm{f}_{\mathrm{o}}=10 \mathrm{~Hz} \text { (Note 2) } \end{aligned}$ | 125 | 175 | - | 125 | 175 | - | - | 175 | - | dB |
| Input Capacitance | $\mathrm{C}_{1 \mathrm{IN}}$ |  | - | 3 | - | - | 3 | - | - | 3 | - | pF |
| Input Resistance Differential-Mod | $e^{R_{\text {IN }}}$ |  | - | 0.4 | - | - | 0.4 | - | - | 0.4 | - | M $\Omega$ |
| Input Resistance Common-Mode | $\mathrm{R}_{\text {INCM }}$ |  | - | 20 | - | - | 20 | - | - | 20 | - | G $\Omega$ |
| Settling Time | $\mathrm{t}_{8}$ | $\begin{aligned} & A_{V}=+1,10 \mathrm{~V} \text { Step } \\ & \text { to } 0.01 \% \end{aligned}$ | - | 2 | - | - | 2 | - | - | 2 | - | $\mu \mathrm{s}$ |

## NOTES:

1. Guaranteed by CMR test.
2. Guaranteed but not $100 \%$ tested.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V},-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq 125^{\circ} \mathrm{C}$ for $\mathrm{OP}-271 \mathrm{~A}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-271A |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX |  |
| Input Offset Voltage | $\mathrm{v}_{\mathrm{OS}}$ |  | - | 115 | 400 | $\mu \mathrm{V}$ |
| Average Input Offset Voltage Drift | $\mathrm{TCV}_{\text {OS }}$ |  | - | 0.4 | 2 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current | $\mathrm{I}_{\mathrm{OS}}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 1.5 | 30 | nA |
| Input Bias Current | $I_{B}$ | $\mathrm{V}_{\mathrm{CM}}=\mathrm{OV}$ | - | 7 | 60 | nA |
| Large-Signal Voltage Gain | $A_{\text {vo }}$ | $\begin{gathered} \mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \\ \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \\ \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ \hline \end{gathered}$ | $\begin{aligned} & 300 \\ & 200 \\ & \hline \end{aligned}$ | $\begin{aligned} & 600 \\ & 500 \\ & \hline \end{aligned}$ | - | $\mathrm{V} / \mathrm{mV}$ |
| Input Voltage Range | IVR | (Note 1) | $\pm 12$ | $\pm 12.5$ | - | V |
| Output Voltage Swing | $\mathrm{V}_{\mathrm{O}}$ | $R_{L} \geq 2 \mathrm{k} \Omega$ | $\pm 12$ | $\pm 13$ | - | V |
| Common-Mode Rejection | CMR | $V_{C M}= \pm 12 \mathrm{~V}$ | 100 | 120 | - | dB |
| Power Supply Rejection Ratio | PSRR | $V_{S}= \pm 4.5 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | 1.0 | 5.6 | $\mu \mathrm{V} / \mathrm{V}$ |
| Supply Current (All Amplifiers) | $\mathrm{I}_{\mathrm{SY}}$ | No Load | - | 5.3 | 7.5 | mA |

NOTE:

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{S}= \pm 15 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{A} \leq+85^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-271A/E |  |  | OP-271F |  |  | OP-271G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Input Offset Voltage | $V_{\text {OS }}$ |  | - | 100 | 330 | - | 215 | 560 | - | 300 | 700 | $\mu \mathrm{V}$ |
| Average Input Offset Voltage Drift | $\mathrm{TCV}_{\mathrm{os}}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 0.4 | 2 | - | 1 | 4 | - | 2.0 | 5 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current | Ios |  | - | 1 | 30 | - | 5 | 40 | - | 15 | 50 | nA |
| Input Bias Current | $I_{B}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 6 | 60 | - | 10 | 70 | - | 15 | 80 | nA |
| Large-Signal |  | $\mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V}$ |  |  |  |  |  |  |  |  |  |  |
| Voltage | $A_{\text {vo }}$ | $R_{L}=10 \mathrm{k} \Omega$ | 300 | 600 | - | 200 | 500 | - | 150 | 400 | - | $\mathrm{V} / \mathrm{mV}$ |
| Gain |  | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | 200 | 500 | - | 100 | 400 | - | 90 | 300 | - |  |
| Input Voltage Range | IVR | (Note 1) | $\pm 12$ | $\pm 12.5$ | - | $\pm 12$ | $\pm 12.5$ | - | $\pm 12$ | $\pm 12.5$ | - | V |
| Output Voltage Swing | $v_{0}$ | $\mathrm{R}_{\mathrm{L}} \geq \mathbf{2 k} \boldsymbol{\Omega}$ | $\pm 12$ | $\pm 13$ | - | $\pm 12$ | $\pm 13$ | - | $\pm 12$ | $\pm 13$ | - | V |
| Common-Mode Rejection | CMR | $\mathrm{V}_{\mathrm{CM}}= \pm 12 \mathrm{~V}$ | 100 | 120 | - | 94 | 115 | - | 90 | 100 | - | dB |
| Power Supply Rejection Ratio | PSRR | $\mathrm{V}_{\mathrm{S}}= \pm 4.5 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | 0.7 | 5.6 | - | 51.8 | 10 | - | 2.0 | 15 | $\mu \mathrm{V} / \mathrm{N}$ |
| Supply Current (All Amplifiers) | ${ }^{\prime} \mathrm{SY}$ | No Load | - | 5.2 | 7.2 | - | 5.2 | 7.2 | - | 5.2 | 7.2 | mA |

1. Guaranteed by CMR test.

OP275*

## FEATURES

Excellent Sonic Characteristics
Low Noise: $6 \mathrm{nV} / \sqrt{\mathrm{Hz}}$
Low Distortion: 0.0006\%
High Slew Rate: 22 V/ $\mu \mathrm{s}$
Wide Bandwidth: 9 MHz
Low Supply Current: 5 mA
Low Offset Voltage: 1 mV
Low Offset Current: 2 nA
Unity Gain Stable
SOIC-8 Package

## APPLICATIONS

High Performance Audio
Active Filters
Fast Amplifiers
Integrators

## GENERAL DESCRIPTION

The OP-275 is the first amplifier to feature the Butler Amplifier front-end. This new front-end design combines both bipolar and JFET transistors to attain amplifiers with the accuracy and low noise performance of bipolar transistors, and the speed and sound quality of JFETs. Total Harmonic Distortion plus Noise equals previous audio amplifiers, but at much lower supply currents.

A very low 1/f corner of below 6 Hz maintains a flat noise density response. Whether noise is measured at either 30 Hz or 1 kHz , it is only $6 \mathrm{nV} / \sqrt{\mathrm{Hz}}$. The JFET portion of the input stage gives the OP-275 its high slew rates to keep distortion low, even when large output swings are required, and the $22 \mathrm{~V} / \mu \mathrm{s}$ slew rate of the OP-275 is the fastest of any standard audio amplifier. Best of all, this low noise and high speed are accomplished using less than 5 mA of supply current, lower than any standard audio amplifier.


Improved dc performance is also provided with bias and offset currents greatly reduced over purely bipolar designs. Input offset voltage is guaranteed at 1 mV and is typically less than $200 \mu \mathrm{~V}$. This allows the OP-275 to be used in many dc coupled or summing applications without the need for special selections or the added noise of additional offset adjustment circuitry.
The output is capable of driving $600 \Omega$ loads to 10 V rms while maintaining low distortion. THD + Noise at 3 V rms is a low $0.0006 \%$.
The OP-275 is specified over the extended industrial $\left(-40^{\circ} \mathrm{C}\right.$ to $+85^{\circ} \mathrm{C}$ ) temperature range. OP-275s are available in both plastic DIP and SOIC-8 packages. SOIC-8 packages are available in 2500 piece reels. Many audio amplifiers are not offered in SOIC-8 surface mount packages for a variety of reasons, however the OP-275 was designed so that it would offer full performance in surface mount packaging.

[^185]
## ELECTRICAL CHARACTERISTICS (@ $\mathrm{v}_{\mathrm{S}}= \pm 15.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise specified)

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| AUDIO PERFORMANCE <br> THD + Noise Voltage Noise Density <br> Current Noise Density Headroom | $e_{n}$ $i_{n}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=3 \mathrm{~V} \mathrm{rms}, \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{f}=1 \mathrm{kHz} \\ & \mathrm{f}=30 \mathrm{~Hz} \\ & \mathrm{f}=1 \mathrm{kHz} \\ & \mathrm{f}=1 \mathrm{kHz} \\ & \mathrm{THD}+\mathrm{Noise} \leq 0.01 \%, \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{~V}_{\mathrm{S}}= \pm 18 \mathrm{~V} \end{aligned}$ |  | $\begin{aligned} & 0.0006 \\ & 7 \\ & 6 \\ & 1.5 \\ & >12.9 \end{aligned}$ |  | \% <br> $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ <br> $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ <br> $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ <br> dBu |
| INPUT CHARACTERISTICS Offset Voltage Input Bias Current Input Offset Current Input Voltage Range Common-Mode Rejection Large Signal Voltage Gain Offset Voltage Drift | $\mathrm{V}_{\mathrm{Os}}$ <br> $\mathrm{I}_{\mathrm{B}}$ <br> $\mathrm{I}_{\mathrm{OS}}$ <br> $\mathrm{V}_{\mathrm{CM}}$ <br> CMR <br> $\mathrm{A}_{\mathrm{vo}}$ <br> $\Delta \mathrm{V}_{\mathrm{OS}} / \Delta \mathrm{T}$ | $\begin{aligned} & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \\ & \mathrm{~V}_{\mathrm{CM}}= \pm 10.5 \mathrm{~V}, \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega,-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{R}_{\mathrm{L}}=600 \Omega \end{aligned}$ | $\begin{aligned} & -10.5 \\ & 80 \\ & 250 \\ & 175 \end{aligned}$ | $\begin{aligned} & 100 \\ & 100 \\ & 2 \\ & 2 \\ & 106 \\ & \\ & 200 \\ & 5 \end{aligned}$ | $\begin{aligned} & 1 \\ & 1.25 \\ & 350 \\ & 400 \\ & \pm 50 \\ & \pm 100 \\ & +10.5 \end{aligned}$ | mV <br> mV <br> nA <br> nA <br> nA <br> nA <br> V <br> dB <br> V/mV <br> $\mathrm{V} / \mathrm{mV}$ <br> $\mathrm{V} / \mathrm{mV}$ <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| OUTPUT CHARACTERISTICS Output Voltage Swing | $\mathrm{V}_{\mathrm{o}}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega,-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{R}_{\mathrm{L}}=600 \Omega, \mathrm{~V}_{\mathrm{S}}= \pm 18 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & -13.5 \\ & -13 \end{aligned}$ | $\begin{aligned} & \pm 13.9 \\ & \pm 13.9 \\ & \pm 16 \end{aligned}$ | $\begin{aligned} & +13.5 \\ & +13 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \end{aligned}$ |
| POWER SUPPLY <br> Power Supply Rejection Ratio <br> Supply Current <br> Supply Voltage Range | PSRR $\mathrm{I}_{\mathrm{SY}}$ $\mathrm{V}_{\mathrm{S}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}= \pm 4.5 \mathrm{~V} \text { to } \pm 18 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 4.5 \mathrm{~V} \text { to } \pm 18 \mathrm{~V}, \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 4.5 \mathrm{~V} \text { to } \pm 18 \mathrm{~V}, \mathrm{~V}_{\mathrm{O}}=0 \mathrm{~V}, \\ & \mathrm{R}_{\mathrm{L}}=\infty,-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 22 \mathrm{~V}, \mathrm{~V}_{\mathrm{O}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=\infty, \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \end{aligned}$ | 85 80 $\pm 4.5$ | $111$ <br> 4 | 5 <br> 5.5 $\pm 22$ | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \\ & \mathrm{~mA} \\ & \mathrm{~mA} \\ & \mathrm{~V} \end{aligned}$ |
| DYNAMIC PERFORMANCE <br> Slew Rate Full-Power Bandwidth Gain Bandwidth Product Phase Margin Overshoot Factor | SR <br> $\mathrm{BW}_{\mathrm{P}}$ <br> GBP <br> $\varnothing$ о | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=100 \mathrm{mV}, \mathrm{~A}_{\mathrm{V}}=+1, \\ & \mathrm{R}_{\mathrm{L}}=600 \Omega, \mathrm{C}_{\mathrm{L}}=100 \mathrm{pF} \end{aligned}$ | 15 | $\begin{aligned} & 22 \\ & 9 \\ & 62 \\ & 10 \end{aligned}$ |  | V/us <br> kHz <br> MHz <br> Degrees <br> \% |

[^186]WAFER TEST LIMITS
( $@ \mathrm{~V}_{\mathrm{S}}= \pm 15.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise specified)

| Parameter | Symbol | Conditions | Limit | Units |
| :---: | :---: | :---: | :---: | :---: |
| Offset Voltage | $\mathrm{V}_{\text {OS }}$ |  | 1 | mV max |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | 350 | $n A$ max |
| Input Offset Current | $\mathrm{I}_{\text {OS }}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | $\pm 50$ | $n A$ max |
| Input Voltage Range ${ }^{1}$ |  |  | $\pm 10.5$ | $V$ min |
| Common-Mode Rejection | CMRR | $\mathrm{V}_{\mathrm{CM}}= \pm 10.5 \mathrm{~V}$ | 80 | dB min |
| Power Supply Rejection Ratio | PSRR | $\mathrm{V}= \pm 4.5 \mathrm{~V}$ to $\pm 18^{\circ} \mathrm{V}$ | 85 | dB min |
| Large Signal Voltage Gain | $\mathrm{A}_{\text {vo }}$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | 250 | $\mathrm{V} / \mathrm{mV}$ min |
| Output Voltage Range | $\mathrm{V}_{\mathrm{O}}$ | $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ | $\pm 13.5$ | V min |
| Supply Current | $\mathrm{I}_{\mathrm{SY}}$ | $\mathrm{V}_{\mathrm{O}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=\infty$ | 5 | mA max |

## NOTES

Electrical tests and wafer probe to the limits shown. Due to variations in assembly methods and normal yield loss, yield after packaging is not guaranteed for standard product dice. Consult factory to negotiate specifications based on dice lot qualifications through sample lot assembly and testing.
${ }^{1}$ Guaranteed by CMR test.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 22$ V
Input Voltage ${ }^{2}$. . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 18$ V
Differential Input Voltage ${ }^{2}$. . . . . . . . . . . . . . . . . . . $\pm 7.5 \mathrm{~V}$
Output Short-Circuit Duration to GND ${ }^{3}$. . . . . . . . Indefinite
Storage Temperature Range
(P, S) Package . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Operating Temperature Range
OP-275G . . . . . . . . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Junction Temperature Range
(P, S) Package . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature Range (Soldering, 60 sec ) . . . . . . $+300^{\circ} \mathrm{C}$

| Package Type | $\boldsymbol{\theta}_{\mathbf{J A}}{ }^{\mathbf{4}}$ | $\boldsymbol{\theta}_{\mathbf{J C}}$ | Units |
| :--- | :--- | :--- | :--- |
| 8-Pin Plastic DIP (P) | 103 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin SOIC (S) | 158 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

NOTES
${ }^{1}$ Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
${ }^{2}$ For supply voltages less than $\pm 22 \mathrm{~V}$, the absolute maximum input voltage is equal to the supply voltage.
${ }^{3}$ Shorts to either supply may destroy the device. See data sheet for full details.
${ }^{4} \theta_{\mathrm{JA}}$ is specified for the worst case conditions, i.e., $\theta_{\mathrm{JA}}$ is specified for device in socket for cerdip, P-DIP, and LCC packages; $\theta_{\text {JA }}$ is specified for device soldered in circuit board for SOIC package.

ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| OP275GP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | $\mathrm{N}-8$ |
| OP275GS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin SOIC | SO-8 |
| OP275GSR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | SOIC-8 Reel, <br> 2500 pcs. |  |
| OP275GBC | $+25^{\circ} \mathrm{C}$ | DICE |  |

[^187]
## DICE CHARACTERISTICS



OP-275 Die Size $0.070 \times 0.108 \mathrm{in}$. (7,560 sq. mils)

## APPLICATIONS

## Short Circuit Protection

The OP-275 has been designed with inherent output short circuit protection to ground.
However shorts to either supply may destroy the device when excessive voltages or currents are applied. For safe operation the output current of the OP- 275 should be design limited to $\pm 30 \mathrm{~mA}$.

## Total Harmonic Distortion

Total Harmonic Distortion + Noise (THD + N) of the OP-275 is well below $0.001 \%$ with any load down to $600 \Omega$. However, this is dependent upon the peak output swing. In Figure 1 it is seen that the THD + Noise with 3 V rms output is below $0.001 \%$. In the following Figure 2, THD + Noise is below $0.001 \%$ for the $10 \mathrm{k} \Omega$ and $2 \mathrm{k} \Omega$ loads but increases to above $0.1 \%$ for the $600 \Omega$ load condition. This is a result of the output swing capability of the OP-275. Notice the results in Figure 3, showing THD vs. $\mathrm{V}_{\mathrm{IN}}(\mathrm{V}$ rms). This figure shows that the THD + Noise remains very low until the output reaches 9.5 volts rms. This performance is similar to competitive products.
The output of the OP-275 is designed to maintain low harmonic distortion while driving $600 \Omega$ loads. However, driving $600 \Omega$ loads with very high output swings results in higher distortion if clipping occurs. A common example of this is in attempting to drive 10 V rms into any load with $\pm 15$ volt supplies. Clipping will occur and distortion will be very high.


Figure 1. $T H D+$ Noise vs. Frequency vs. $R_{\text {LOAD }}$


Figure 2. $T H D+$ Noise vs. $R_{\text {LOAD }} ; V_{I N}=10 \mathrm{~V} r m s, \pm 18 \mathrm{~V}$ Supplies


Figure 3. Headroom, THD + Noise vs. Output Amplitude ( V rms); $R_{\text {LOAD }}=600 \Omega, V_{\text {SUP }}= \pm 18 \mathrm{~V}$

To attain low harmonic distortion with large output swings, supply voltages may be increased. Figure 4 shows the performance of the OP- 275 driving $600 \Omega$ loads with supply voltages varying from $\pm 18$ to $\pm 20$ volts. Notice that with $\pm 18$ volt supplies the distortion is fairly high, while with $\pm 20$ volt supplies it is a very low $0.0007 \%$.


Figure 4. THD + Noise vs. Supply Voltage

## Noise

The voltage noise density of the OP-275 is below $7 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ from 30 Hz . This enables low noise designs to have good performance throughout the full audio range. Figure 5 shows a typical OP-275 with a $1 / \mathrm{f}$ corner at 5.2 Hz .


Figure 5. $1 / f$ Noise Corner, $V_{s}= \pm 15 \mathrm{~V}, A_{V}=1000$

## Noise Testing

For audio applications the noise density is usually the most important noise parameter. For characterization the OP-275 is tested using an Audio Precision, System One. The input signal to the Audio Precision must be amplified enough to measure accurately. For the OP-275 the noise is gained by approximately 1020 using the circuit shown in Figure 6. Any readings on the Audio Precision must then be divided by the gain. In implementing this test fixture, good supply bypassing is essential.


Figure 6. Noise Test Fixture

## Driving Capacitive Loads

The OP-275 was designed to drive both resistive loads to $600 \Omega$ and capacitive loads of over 1000 pF and maintain stability. While there is a degradation in bandwidth when driving capacitive loads, the designer need not worry about device stability. The graph in Figure 7 shows the 0 dB bandwidth of the OP-275 with capacitive loads from 10 pF to 1000 pF .


Figure 7. Bandwidth vs. $C_{\text {LOAD }}$


Figure 8. Closed-Loop Gain and Phase, $A_{V}=+1$


Figure 9. Open-Loop Gain and Phase

## FEATURES

Rail-to-Rail Input and Output
High Output Current: 50 mA
Single-Supply: +5 V to +12 V
Wide Bandwidth: 2 MHz
High Slew Rate: 5 V/ $\mu \mathrm{s}$
Low Distortion: 0.01\%
Unity Gain Stable
No Phase Reversal
APPLICATIONS
Multimedia
Telecom
DAA Transformer Driver
LCD Driver
Low Voltage Servo Control

FUNCTIONAL BLOCK DIAGRAMS

8-Lead Narrow-Body SO
(S Suffix)


8-Lead Epoxy Dip
(P Suffix)


## GENERAL DESCRIPTION

The OP279 is a dual, single-supply, high output current amplifier. It is designed for applications that require drive currents of up to 80 mA in low voltage applications.

Driving headphones directly or transformers or power transistors are applications that benefit from the OP279's high output current. The powerful output is combined with a unique input stage that maintains very low distortion with wide commonmode range even in single supply designs.
OP279s are useful amplifiers for buffering either ASICs or DACs when greater drive capability is needed than can usually be provided by CMOS outputs.

Bandwidth is 2 MHz and slew the rate is $5 \mathrm{~V} / \mu \mathrm{s}$, making these amplifiers well suited for single supply applications that require audio bandwidths when used in high gain configurations. Operation is guaranteed from voltages as low as 4.5 V , up to 12 V . When using the OP279 in +5 V systems, very good audio performance can be attained. THD is below $0.01 \%$ with a $600 \Omega$ load, and noise is a respectable $22 \mathrm{nV} / \sqrt{\mathrm{Hz}}$. Supply current is less than 2 mA per amplifier.
The OP279 is available in 8-pin plastic DIP and SO-8 surface mount packages. They are specified over the extended industrial $\left(-40^{\circ} \mathrm{C}\right.$ to $\left.+85^{\circ} \mathrm{C}\right)$ temperature range.

[^188]
## OP279-SPECIFICATIONS





| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT CHARACTERISTICS |  | - |  |  |  |  |
| Offset Voltage | $\mathrm{V}_{\text {OS }}$ |  |  |  | 4 | mV |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ |  |  | 400 | 600 | nA |
| Input Offset Current | $\mathrm{I}_{\mathrm{os}}$ |  |  |  | $\pm 50$ | nA |
| Input Voltage Range |  |  | -5 |  | +5 | V |
| Common-Mode Rejection Ratio | CMRR | $\mathrm{V}_{\mathrm{CM}}=-5 \mathrm{~V}$ to +5 V | 70 | 86 |  |  |
| Large Signal Voltage Gain | $\mathrm{A}_{\mathrm{vo}}$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | 100 | 1000 |  | V/mV |
| Offset Voltage Drift | $\Delta \mathrm{V}_{\text {os }} / \Delta \mathrm{T}$ |  |  |  |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Bias Current Drift | $\Delta \mathrm{I}_{\mathrm{B}} / \Delta \mathrm{T}$ |  |  | -1.6 |  | $\mathrm{nA} /{ }^{\circ} \mathrm{C}$ |
| OUTPUT CHARACTERISTICS |  |  |  |  |  |  |
| Output Voltage High | $\mathrm{V}_{\mathrm{OH}}$ | $\mathrm{I}_{\mathrm{L}}=10 \mathrm{~mA}$ Source | +4.9 |  |  | V |
| Output Voltage Low | $\mathrm{V}_{\text {OL }}$ | $\mathrm{I}_{\mathrm{L}}=10 \mathrm{~mA} \mathrm{Sink}$ |  |  | -4.9 | V |
| Short Circuit Limit | $\mathrm{I}_{\text {SC }}$ | Source |  | 80 |  | mA |
|  |  | Sink |  | 80 |  | mA |
| Open-Loop Output Impedance | $\mathrm{Z}_{\text {OUT }}$ | $\mathrm{f}=1 \mathrm{MHz}, \mathrm{A}_{\mathrm{V}}=+1$ |  | 15 |  | $\Omega$ |
| POWER SUPPLY |  |  |  |  |  |  |
| Power Supply Rejection Ratio | PSRR | $\mathrm{V}_{\mathrm{S}}= \pm 2.5 \mathrm{~V}$ to $\pm 6 \mathrm{~V},-40 \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ | 70 | 25 |  | dB |
| Supply Current/Amplifier | $\mathrm{I}_{\text {SY }}$ | $\mathrm{V}_{\mathrm{S}}= \pm 6 \mathrm{~V}, \mathrm{~V}_{\mathrm{O}}=0 \mathrm{~V}$ |  | 2 | 2.6 | mA |
| Supply Voltage Range | $\mathrm{V}_{\text {S }}$ |  | +4.75 |  | $\pm 6$ | V |
| DYNAMIC PERFORMANCE |  |  |  |  |  |  |
| Slew Rate | SR | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ |  | 5 |  |  |
| Full-Power Bandwidth | $\mathrm{BW}_{\mathrm{P}}$ | 1\% Distortion |  |  |  | kHz |
| Gain Bandwidth Product | GBP |  |  | 2 |  | MHz |
| Phase Margin | фо |  |  |  |  | Degrees |
| NOISE PERFORMANCE |  |  |  |  |  |  |
| Voltage Noise | $\mathrm{e}_{\mathrm{n}} \mathrm{p}$-p | 0.1 Hz to 10 Hz |  | 2 |  |  |
| Voltage Noise Density | $\mathrm{e}_{\mathrm{n}}$ | $\mathrm{f}=1 \mathrm{kHz}$ |  | 22 |  | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| Current Noise Density | $\mathrm{i}_{\mathrm{n}}$ |  |  |  |  | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |

Specifications subject to change without notice.

[^189]
## Dual/Quad Low Power, High Speed JFET Operational Amplifiers

## FEATURES

High Slew Rate: $9 \mathrm{~V} / \mu \mathrm{s}$
Wide Bandwidth: $\mathbf{4} \mathbf{~ M H z}$
Low Supply Current: $\mathbf{2 5 0} \mu \mathrm{A} /$ Amplifier
Low Offset Voltage: $\mathbf{3} \mathbf{~ m V}$
Low Bias Current: 100 pA
Fast Settling Time
Common-Mode Range Includes V+ Unity Gain Stable
APPLICATIONS
Active Filters
Fast Amplifiers
Integrators
Supply Current Monitoring

## GENERAL DESCRIPTION

The OP-282/OP-482 dual and quad operational amplifiers feature excellent speed at exceptionally low supply currents. Slew rate exceeds $7 \mathrm{~V} / \mu \mathrm{s}$ with supply current under $250 \mu \mathrm{~A}$ per amplifier. These unity gain stable amplifiers have a typical gainbandwidth of 4 MHz .
The JFET input stage of the OP-282/OP-482 insures bias current is typically a few picoamps and below 500 pA over the full temperature range. Offset voltage is under 3 mV for the dual and under 4 mV for the quad.
With a wide output swing, within 1.5 volts of each supply, low power consumption and high slew rate, the OP-282/OP-482 are ideal for battery-powered systems or power restricted applications. An input common-mode range that includes the positive supply makes the OP-282/OP-482 an excellent choice for highside signal conditioning.
The OP-282/OP-482 are specified over the extended industrial temperature range. Both dual and quad amplifiers are available in plastic and ceramic DIP plus SOIC surface mount packages. Contact your local sales office for MIL-STD-883 data sheet and availability.

## PIN CONNECTIONS



20-Position Chip Carrier
(RC Suffix)


This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

## OP282/OP482 - SPECIFICATIONS

ELECTRICAL CHARACTERISTICS $\left(@ V_{S}= \pm 15.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right.$ unless otherwise noted)

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT CHARACTERISTICS <br> Offset Voltage <br> Offset Voltage <br> Input Bias Current <br> Input Offset Current <br> Input Voltage Range Common-Mode Rejection Large Signal Voltage Gain <br> Offset Voltage Drift Bias Current Drift | $\mathrm{V}_{\mathrm{os}}$ <br> $\mathrm{V}_{\mathrm{OS}}$ <br> $\mathrm{I}_{\mathrm{B}}$ <br> $\mathrm{I}_{\mathrm{OS}}$ <br> CMR <br> $\mathrm{A}_{\mathrm{vo}}$ <br> $\Delta \mathrm{V}_{\mathrm{Os}} / \Delta \mathrm{T}$ <br> $\Delta \mathrm{I}_{\mathrm{B}} / \Delta \mathrm{T}$ | $\begin{aligned} & \text { OP-282 } \\ & \text { OP-282, }-40 \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \text { OP-482 } \\ & \text { OP-482, }-40 \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V}, \text { Note } 1 \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V}, \text { Note } 1 \\ & -11 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CM}} \leq+15 \mathrm{~V},-40 \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega,-40 \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \end{aligned}$ | $\begin{aligned} & -11 \\ & 70 \\ & 20 \\ & 15 \end{aligned}$ | $\begin{aligned} & 0.2 \\ & 0.2 \\ & 3 \\ & 1 \\ & 90 \\ & 10 \\ & 8 \end{aligned}$ | $\begin{aligned} & 3 \\ & 4.5 \\ & 4 \\ & 6 \\ & 100 \\ & 500 \\ & 50 \\ & 250 \\ & +15 \end{aligned}$ | mV <br> mV <br> mV <br> mV <br> pA <br> pA <br> pA <br> pA <br> V <br> dB <br> $\mathrm{V} / \mathrm{mV}$ <br> $\mathrm{V} / \mathrm{mV}$ <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ <br> $\mathrm{pA} /{ }^{\circ} \mathrm{C}$ |
| OUTPUT CHARACTERISTICS <br> Output Voltage Swing Short Circuit Limit Open-Loop Output Impedance | $\begin{aligned} & \mathrm{V}_{\mathrm{O}} \\ & \mathrm{I}_{\mathrm{SC}} \\ & \mathrm{Z}_{\mathrm{OUT}} \end{aligned}$ | $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ <br> Source <br> Sink $\mathrm{f}=1 \mathrm{MHz}$ | $\begin{aligned} & -13.5 \\ & 3 \\ & -8 \end{aligned}$ | $\begin{aligned} & \pm 13.9 \\ & 10 \\ & -12 \\ & 200 \end{aligned}$ | 13.5 | V <br> mA <br> mA <br> $\Omega$ |
| POWER SUPPLY <br> Power Supply Rejection Ratio <br> Supply Current/Amplifier Supply Voltage Range | PSRR <br> $\mathrm{I}_{\text {SY }}$ <br> $\mathrm{V}_{\mathrm{s}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}= \pm 4.5 \mathrm{~V} \text { to } \pm 18 \mathrm{~V} \\ & -40 \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{O}}=0 \mathrm{~V},-40 \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \end{aligned}$ | $\pm 4.5$ | 25 210 | $\begin{aligned} & 316 \\ & 250 \\ & \pm 18 \end{aligned}$ | $\begin{aligned} & \mu \mathrm{V} / \mathrm{V} \\ & \mu \mathrm{~A} \\ & \mathrm{~V} \end{aligned}$ |
| DYNAMIC PERFORMANCE <br> Slew Rate <br> Full-Power Bandwidth <br> Settling Time Gain Bandwidth Product Phase Margin | SR <br> $\mathrm{BW}_{\mathrm{P}}$ <br> $\mathrm{t}_{\mathrm{s}}$ <br> GBP <br> $\varnothing$ о | $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ <br> 1\% Distortion <br> To 0.01\% | 7 | $\begin{aligned} & 9 \\ & 125 \\ & 1.6 \\ & 4 \\ & 55 \end{aligned}$ |  | V/us <br> kHz <br> $\mu \mathrm{s}$ <br> MHz <br> Degrees |
| NOISE PERFORMANCE <br> Voltage Noise Voltage Noise Density Current Noise Density | $\begin{aligned} & e_{\mathrm{n}} \mathrm{p}-\mathrm{p} \\ & \mathrm{e}_{\mathrm{n}} \\ & \mathrm{i}_{\mathrm{n}} \\ & \hline \end{aligned}$ | $\begin{aligned} & 0.1 \mathrm{~Hz} \text { to } 10 \mathrm{~Hz} \\ & \mathrm{f}=1 \mathrm{kHz} \end{aligned}$ |  | $\begin{aligned} & 1.3 \\ & 36 \\ & 0.01 \end{aligned}$ |  | $\begin{aligned} & \mu \mathrm{Vp}-\mathrm{p} \\ & \mathrm{nV} / \sqrt{\mathrm{Hz}} \\ & \mathrm{pA} / \sqrt{\mathrm{Hz}} \end{aligned}$ |

## NOTE

${ }^{1}$ The input bias and offset currents are tested at $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=+85^{\circ} \mathrm{C}$. Bias and offset currents are guaranteed but not tested at $-40^{\circ} \mathrm{C}$.
Specifications subject to change without notice.
WAFER TEST LIMITS @ $\mathrm{V}_{\mathrm{s}}= \pm 15.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)

| Parameter | Symbol | Conditions | Limit | Units |
| :---: | :---: | :---: | :---: | :---: |
| Offset Voltage | $\mathrm{V}_{\text {Os }}$ | OP-282 | 3 | mV max |
| Offset Voltage | $\mathrm{V}_{\text {OS }}$ | OP-482 | 4 | mV max |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | 100 | pA max |
| Input Offset Current | $\mathrm{I}_{\text {OS }}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | 50 | pA max |
| Input Voltage Range ${ }^{1}$ |  |  | $-11,+15$ | V min/max |
| Common-Mode Rejection | CMRR | $-11 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CM}} \leq+15 \mathrm{~V}$ | 70 | dB min |
| Power Supply Rejection Ratio | PSRR | $\mathrm{V}= \pm 4.5 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | 316 | $\mu \mathrm{V} / \mathrm{V}$ |
| Large Signal Voltage Gain | $\mathrm{A}_{\text {vo }}$ | $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ | 20 | $\mathrm{V} / \mathrm{mV}$ min |
| Output Voltage Range | $\mathrm{V}_{\mathrm{O}}$ | $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ | $\pm 13.5$ | $V \min$ |
| Supply Current/Amplifier | $\mathrm{I}_{\text {SY }}$ | $\mathrm{V}_{\mathrm{O}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=\infty$ | 250 | $\mu \mathrm{A}$ max |

[^190]
## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

| Supply Voltage | $\pm 18 \mathrm{~V}$ |
| :---: | :---: |
| Input Voltage ${ }^{2}$ | 18 V |
| Differential Input Voltage ${ }^{2}$ | 36 V |
| Output Short-Circuit Duration | Indefinite |
| Storage Temperature Range |  |
| Y, Z, RC Packages | $-65^{\circ} \mathrm{C}$ to $+175^{\circ} \mathrm{C}$ |
| P, S Packages | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Operating Temperature Range |  |
| OP-282A, OP-482A | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| OP-282G, OP-482G | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Junction Temperature Range |  |
| Y, Z, RC Packages | $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| P, S Packages | $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
|  | $+300^{\circ} \mathrm{C}$ |


| Package Type | $\boldsymbol{\theta}_{\mathbf{J A}}{ }^{\mathbf{3}}$ | $\boldsymbol{\theta}_{\mathbf{J C}}$ | Units |
| :--- | :--- | :--- | :--- |
| 8-Pin Cerdip (Z) | 148 | 16 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin Plastic DIP (P) | 103 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin SOIC (S) | 158 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 14-Pin Cerdip (Y) | 108 | 16 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 14-Pin Plastic DIP (P) | 83 | 39 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 14-Pin SOIC (S) | 120 | 36 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 20-Contact LCC (RC) | 98 | 38 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTES

${ }^{1}$ Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
${ }^{2}$ For supply voltages less than $\pm 18 \mathrm{~V}$, the absolute maximum input voltage is equal to the supply voltage.
${ }^{3} \theta_{\mathrm{JA}}$ is specified for the worst case conditions, i.e., $\theta_{\mathrm{JA}}$ is specified for device in socket for cerdip, P-DIP, and LCC packages; $\theta_{\mathrm{JA}}$ is specified for device soldered in circuit board for SOIC package.

## DICE CHARACTERISTICS



OP-282 Die Size $0.063 \times 0.060$ Inch, 3,780 Sq. Mils


OP-482 Die Size $0.070 \times 0.098$ Inch, 6,860 Sq. Mils

## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| OP282AZ/883 | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Cerdip | Q-8 |
| OP482AY/883 | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 14-Pin Cerdip | Q-14 |
| OP482ARC $/ 883$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 20-Contact LCC | $\mathrm{E}-20 \mathrm{~A}$ |
| OP282GP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | $\mathrm{N}-8$ |
| OP282GS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin SOIC | SO-8 |
| OP482GP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 14-Pin Plastic DIP | N-14 |
| OP482GS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 14-Pin SOIC | SO-14 |
| OP282GBC | $+25^{\circ} \mathrm{C}$ | DICE |  |
| OP482GBC | $+25^{\circ} \mathrm{C}$ | DICE |  |

[^191]
## FEATURES

Low Offset Voltage: $250 \mu \mathrm{~V}$
Low Noise: $6 \mathrm{nV} / \sqrt{\mathrm{Hz}}$
Low Distortion: 0.0006\%
High Slew Rate: 22 V/ $\mu \mathrm{s}$
Wide Bandwidth: $9 \mathbf{~ M H z}$
Low Supply Current: 5 mA
Low Offset Current: 2 nA
Unity-Gain Stable
SO-8 Package
APPLICATIONS
High Performance Audio
Active Filters
Fast Amplifiers
Integrators

## GENERAL DESCRIPTION

The OP-285 is a precision high speed amplifier featuring the Butler Amplifier front-end. This new front-end design combines the accuracy and low noise performance of bipolar transistors with the speed of JFETs. This yields an amplifier with high slew rates, low offset and good noise performance at low supply currents. Bias currents are also low compared to bipolar designs.
The OP- 285 offers the slew rate and low power of a JFET amplifier combined with the precision, low noise and low drift of a bipolar amplifier. Input offset voltage is laser-trimmed and guaranteed less than $250 \mu \mathrm{~V}$. This makes the OP- 285 useful in dc coupled or summing applications without the need for special selections or the added noise of additional offset adjustment circuitry. Slew rates of $22 \mathrm{~V} / \mu \mathrm{s}$ and a bandwidth of 9 MHz make the OP-285 one of the most accurate medium speed amplifiers available.

PIN CONNECTIONS
8-Lead Narrow-Body SO
(S Suffix)


8-Lead Epoxy DIP (P Suffix)


The combination of low noise, speed and accuracy can be used to build high speed instrumentation systems. Circuits such as instrumentation amplifiers, ramp generators, bi-quad filters and dc coupled audio systems are all practical with the OP-285.

For applications that require long term stability, the OP-285 has a guaranteed maximum long term drift specification.
The OP-285 is specified over the XIND-extended industrial( $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ) temperature range. OP-285s are available in 8 -pin plastic DIP and SOIC-8 surface mount packages.

[^192]ELECTRICAL CHARAGTERISTICS ( $\mathrm{V}_{\mathrm{S}}= \pm 15.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT CHARACTERISTICS <br> Offset Voltage Offset Voltage Input Bias Current Input Bias Current Input Offset Current Input Offset Current Input Voltage Range Common-Mode Rejection <br> Large Signal Voltage Gain Large Signal Voltage Gain Large Signal Voltage Gain Common-Mode Input Capacitance Differential Input Capacitance Long Term Offset Voltage Offset Voltage Drift | $\mathrm{V}_{\mathrm{OS}}$ <br> $\mathrm{V}_{\text {Os }}$ <br> $\mathrm{I}_{\mathrm{B}}$ <br> $\mathrm{I}_{\mathrm{B}}$ <br> $\mathrm{I}_{\mathrm{OS}}$ <br> $\mathrm{I}_{\mathrm{OS}}$ <br> $\mathrm{V}_{\mathrm{CM}}$ <br> CMRR <br> $\mathrm{A}_{\mathrm{vo}}$ <br> $\mathrm{A}_{\mathrm{vo}}$ <br> $\mathrm{A}_{\text {vo }}$ <br> $\Delta V_{\text {OS }}$ <br> $\Delta V_{\mathrm{OS}} / \Delta \mathrm{T}$ | $\begin{aligned} & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{CM}}= \pm 10.5 \mathrm{~V}, \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega,-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{R}_{\mathrm{L}}=600 \Omega \end{aligned}$ <br> Note 1 | $\begin{aligned} & -10.5 \\ & 80 \\ & 250 \\ & 175 \end{aligned}$ | 35 <br> 100 <br> 2 <br> 2 <br> 106 <br> 200 <br> 7.5 <br> 3.7 <br> 1 | $\begin{aligned} & 250 \\ & 600 \\ & 350 \\ & 400 \\ & \pm 50 \\ & \pm 100 \\ & +10.5 \\ & \\ & \\ & \\ & 300 \end{aligned}$ | $\mu \mathrm{V}$ <br> $\mu \mathrm{V}$ <br> nA <br> nA <br> nA <br> nA <br> V <br> dB <br> $\mathrm{V} / \mathrm{mV}$ <br> $\mathrm{V} / \mathrm{mV}$ <br> $\mathrm{V} / \mathrm{mV}$ <br> pF <br> pF <br> $\mu \mathrm{V}$ <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| OUTPUT CHARACTERISTICS Output Voltage Swing Output Voltage Swing | $\begin{aligned} & \mathrm{V}_{\mathrm{O}} \\ & \mathrm{~V}_{\mathrm{O}} \end{aligned}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega,-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{R}_{\mathrm{L}}=600 \Omega, \mathrm{~V}_{\mathrm{S}}= \pm 18 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & -13.5 \\ & -13 \end{aligned}$ | $\begin{aligned} & \pm 13.9 \\ & \pm 13.9 \\ & -16 /+14 \end{aligned}$ | $\begin{aligned} & +13.5 \\ & +13 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \end{aligned}$ |
| POWER SUPPLY <br> Power Supply Rejection Ratio Power Supply Rejection Ratio <br> Supply Current <br> Supply Current <br> Supply Voltage Range | PSRR PSRR <br> $I_{S Y}$ <br> $I_{S Y}$ <br> VS | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}= \pm 4.5 \mathrm{~V} \text { to } \pm 18 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 4.5 \mathrm{~V} \text { to } \pm 18 \mathrm{~V}, \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 4.5 \mathrm{~V} \text { to } \pm 18 \mathrm{~V}, \mathrm{~V}_{\mathrm{O}}=0 \mathrm{~V}, \\ & \mathrm{R}_{\mathrm{L}}=\infty,-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 22 \mathrm{~V}, \mathrm{~V}_{\mathrm{O}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=\infty, \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \end{aligned}$ | 85 $80$ $\pm 4.5$ | $111$ $4$ | 5 <br> 5.5 <br> $\pm 22$ | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \\ & \mathrm{~mA} \\ & \mathrm{~mA} \\ & \mathrm{~V} \end{aligned}$ |
| DYNAMIC PERFORMANCE <br> Slew Rate <br> Gain Bandwidth Product <br> Phase Margin <br> Settling Time <br> Settling Time <br> Distortion <br> Voltage Noise Density Voltage Noise Density Current Noise Density Headroom | SR <br> GBP <br> $\theta 0$ <br> $t_{s}$ <br> $t_{s}$ <br> $\mathrm{e}_{\mathrm{n}}$ <br> $\mathrm{e}_{\mathrm{n}}$ <br> $i_{n}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & \\ & \text { To } 0.1 \%, 10 \mathrm{~V} \text { Step } \\ & \text { To } 0.01 \%, 10 \mathrm{~V} \text { Step } \\ & \mathrm{A}_{\mathrm{V}}=+1, \mathrm{~V}_{\text {OUT }}=8.5 \mathrm{~V} \text { p-p, } \\ & \mathrm{f}=1 \mathrm{kHz}, \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & \mathrm{f}=30 \mathrm{~Hz} \\ & \mathrm{f}=1 \mathrm{kHz} \\ & \mathrm{f}=1 \mathrm{kHz} \\ & \text { THD }+\mathrm{Noise} \leq 0.01 \% \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{~V}_{\mathrm{S}}= \pm 18 \mathrm{~V} \end{aligned}$ | 15 | $\begin{aligned} & 22 \\ & 9 \\ & 62 \\ & 625 \\ & 750 \\ & -104 \\ & 7 \\ & 6 \\ & 0.9 \\ & >12.9 \end{aligned}$ |  | V/us <br> MHz <br> Degrees <br> ns <br> ns <br> dB <br> $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ <br> $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ <br> $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ <br> dBu |

## NOTE

${ }^{1}$ Long term offset voltage is guaranteed by a 1000 hour life test performed on three independent wafer lots at $+125^{\circ} \mathrm{C}$, with an LTPD of 1.3 . Specifications subject to change without notice.

| Parameter | Symbol | Conditions | Limit | Units |
| :---: | :---: | :---: | :---: | :---: |
| Offset Voltage | $\mathrm{V}_{\text {OS }}$ |  | 250 | $\mu \mathrm{V}$ max |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | 350 | $n A \max$ |
| Input Offset Current | $\mathrm{I}_{\text {OS }}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | $\pm 50$ | $n A$ max |
| Input Voltage Range ${ }^{1}$ | $V_{C M}$ |  | $\pm 10.5$ | $V$ min |
| Common-Mode Rejection | CMRR | $\mathrm{V}_{\mathrm{CM}}= \pm 10.5 \mathrm{~V}$ | 80 | dB min |
| Power Supply Rejection Ratio | PSRR | $\mathrm{V}= \pm 4.5 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | 85 | dB |
| Large Signal Voltage Gain | $\mathrm{A}_{\mathrm{V}_{0}}$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | 250 | $\mathrm{V} / \mathrm{mV}$ min |
| Output Voltage Range | $\mathrm{V}_{\mathbf{O}}$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | 13 | $V$ min |
| Supply Current | $\mathrm{I}_{\text {SY }}$ | $\mathrm{V}_{\mathrm{O}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=\infty$ | 5 | mA max |

## NOTES

Electrical tests and wafer probe to the limits shown. Due to variations in assembly methods and normal yield loss, yield after packaging is not guaranteed for standard product dice. Consult factory to negotiate specifications based on dice lot qualifications through sample lot assembly and testing.
${ }^{1}$ Guaranteed by CMR test.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

| Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . 222 V |  |
| :---: | :---: |
| Input Voltage ${ }^{2}$. . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 18 \mathrm{~V}$ |  |
| Differential Input Voltage ${ }^{2}$. . . . . . . . . . . . . . . . . . $\pm 7.5 \mathrm{~V}$ |  |
| Output Short-Circuit Duration to Gnd ${ }^{3}$. . . . . . . . . Indefinite |  |
| Storage Temperature Range |  |
| P, S Package | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Operating Temperature Range |  |
| OP-285G | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Junction Temperature Range |  |
| P, S Package | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Lead Temperature Range (Soldering, | $+300^{\circ} \mathrm{C}$ |


| Package Type | $\boldsymbol{\theta}_{\mathbf{J A}}{ }^{\mathbf{4}}$ | $\boldsymbol{\theta}_{\mathbf{J C}}$ | Units |
| :--- | :---: | :---: | :---: |
| 8-Pin Plastic DIP (P) | 103 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin SOIC (S) | 158 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTES

${ }^{1}$ Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
${ }^{2}$ For supply voltages less than $\pm 7.5 \mathrm{~V}$, the absolute maximum input voltage is equal to the supply voltage.
${ }^{3}$ Shorts to either supply may destroy the device. See data sheet for full details. ${ }^{4} \theta_{\mathrm{JA}}$ is specified for the worst case conditions, i.e., $\theta_{\mathrm{JA}}$ is specified for device in socket for cerdip, P-DIP, and LCC packages; $\theta_{\mathrm{JA}}$ is specified for device soldered in circuit board for SOIC package.

ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| OP285GP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | N-8 |
| OP285GS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin SOIC | SO-8 |
| OP285GSR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | SO-8 Reel, 2500 pcs. |  |
| OP285GBC | $+25^{\circ} \mathrm{C}$ | DICE |  |

[^193]DICE CHARACTERISTICS


OP-285 Die Size $0.070 \times 0.108$ inch, 7,560 sq. mils
Substrate (Die Backside) Is Connected to VTransistor Count, 45


Output Voltage Swing vs. Supply Voltage


Slew Rate vs. Temperature


Common-Mode Rejection vs. Frequency


Open-Loop Gain vs. Temperature


Closed-Loop Gain vs. Frequency


Power Supply Rejection vs. Frequency


Slew Rate vs. Differential Input Voltage


Closed-Loop Output Impedance vs. Frequency


Open-Loop Gain, Phase vs.
Frequency


## Gain Bandwidth Product, Phase Margin vs. Temperature



Maximum Output Swing vs. Frequency


Input Bias Current vs. Temperature


Small-Signal Overshoot vs. Load Capacitance


Supply Current vs. Supply Voltage


Current Noise Density vs. Frequency


Maximum Output Voltage vs. Load Resistance


Short Circuit Current vs. Temperature

$t_{C} V_{o s}$ Distribution


Input Offset $\left(V_{O S}\right)$ Distribution


Settling Time vs. Step Size


Slew Rate vs. Capacitive Load


Negative Slew Rate
$R_{L}=2 k \Omega, V_{S}= \pm 15 \mathrm{~V}, A_{V}=+1$


Small Signal Response
$R_{L}=2 \mathrm{k} \Omega, V_{S}= \pm 15 \mathrm{~V}, A_{V}=+1$


Positive Slew Rate
$R_{L}=2 \mathrm{k} \Omega, V_{S}= \pm 15 \mathrm{~V}, A_{V}=+1$


## OP-285 Voltage Noise Density vs.

Frequency $V_{S}= \pm 15 \mathrm{~V}, A_{V}=1000$

## APPLICATIONS

## Short Circuit Protection

The OP-285 has been designed with inherent short circuit protection to ground. An internal $30 \Omega$ resistor, in series with the output, limits the output current at room temperature to $\mathrm{I}_{\mathrm{SC}}{ }^{+}$ $=40 \mathrm{~mA}$ and $\mathrm{I}_{\mathrm{SC}^{-}}=-90 \mathrm{~mA}$, typically, with $\pm 15 \mathrm{~V}$ supplies.

However, shorts to either supply may destroy the device when excessive voltages or current are applied. If it is possible for a user to short an output to a supply, for safe operation, the output current of the OP- 285 should be design-limited to $\pm 30 \mathrm{~mA}$, as shown in Figure 1.

$A 1=1 / 2$ OP-285
Figure 1. Recommended Output Short Circuit Protection

## Input Over Current Protection

The maximum input differential voltage that can be applied to the OP-285 is determined by a pair of internal Zener diodes connected across the inputs. They limit the maximum differential input voltage to $\pm 7.5 \mathrm{~V}$. This is to prevent emitter-base junction breakdown from occurring in the input stage of the OP-285 when very large differential voltages are applied. However, in order to preserve the OP-285's low input noise voltage, internal resistance in series with the inputs were not used to limit the current in the clamp diodes. In small-signal applications, this is not an issue; however, in industrial applications, where large differential voltages can be inadvertently applied to the device, large transient currents can be made to flow through these diodes. The diodes have been designed to carry a current of $\pm 8 \mathrm{~mA}$; and, in applications where the OP-285's differential voltage were to exceed $\pm 7.5 \mathrm{~V}$, the resistor values shown in Figure 2 safely limit the diode current to $\pm 8 \mathrm{~mA}$.


Figure 2. OP-285 Input Over Current Protection

## Output Voltage Phase Reversal

Since the OP-285's input stage combines bipolar transistors for low noise and p-channel JFETs for high speed performance, the output voltage of the OP-285 may exhibit phase reversal if either of its inputs exceed its negative common-mode input voltage. This might occur in very severe industrial applications where a sensor, or system, fault might apply very large voltages on the inputs of the OP-285. Even though the input voltage range of the OP-285 is $\pm 10.5 \mathrm{~V}$, an input voltage of approximately -13.5 V will cause output voltage phase reversal. In inverting amplifier configurations, the OP-285's internal 7.5 V input clamping diodes will prevent phase reversal; however, they will not prevent this effect from occurring in noninverting applications. For these applications, the fix is a simple one and is illus-
trated in Figure 3. A $3.92 \mathrm{k} \Omega$ resistor in series with the noninverting input of the OP-285 cures the problem.


Figure 3. Output Voltage Phase Reversal Fix

## Overload, or Overdrive, Recovery

Overload, or overdrive, recovery time of an operational amplifier is the time required for the output voltage to recover to a rated output voltage from a saturated condition. This recovery time is important in applications where the amplifier must recover quickly after a large abnormal transient event. The circuit shown in Figure 4 was used to evaluate the OP-285's overload recovery time. The OP-285 takes approximately $1.2 \mu \mathrm{~s}$ to recover to $\mathrm{V}_{\text {OUT }}=+10 \mathrm{~V}$ and approximately $1.5 \mu \mathrm{~s}$ to recover to $\mathrm{V}_{\text {OUT }}=-10 \mathrm{~V}$.


Figure 4. Overload Recovery Time Test Circuit

## Driving the Analog Input of an A/D Converter

Settling characteristics of operational amplifiers also include the amplifier's ability to recover, i.e., settle, from a transient output current load condition. When driving the input of an A/D converter, especially successive-approximation converters, the amplifier must maintain a constant output voltage under dynamically changing load current conditions. In these types of converters, the comparison point is usually diode clamped, but it may deviate several hundred millivolts resulting in high frequency modulation of the A/D input current. Amplifiers that exhibit high closed-loop output impedances and/or low unitygain crossover frequencies recover very slowly from output load current transients. This slow recovery leads to linearity errors or missing codes because of errors in the instantaneous input voltage. Therefore, the amplifier chosen for this type of application should exhibit low output impedance and high unity-gain bandwidth so that its output has had a chance to settle to its nominal value before the converter makes its comparison.
The circuit in Figure 5 illustrates a settling measurement circuit for evaluating the recovery time of an amplifier from an output load current transient. The amplifier is configured as a follower with a very high speed current generator connected to its output. In this test, a 1 mA transient current was used. As shown in Figure 6, the OP-285 exhibits an extremely fast recovery time of 139 ns to $0.01 \%$. Because of its high gain-bandwidth product,


Figure 5. Transient Output Load Current Test Fixture
high open-loop gain, and low output impedance, the OP-285 is ideally suited to drive high speed A/D converters.


Figure 6. OP-285's Output Load Current Recovery Time

## Measuring Settling Time

The design of OP-285 combines high slew rate and wide gainbandwidth product to produce a fast-settling ( $\mathrm{t}_{\mathrm{s}}<1 \mu \mathrm{~s}$ ) amplifier for 8 - and 12 -bit applications. The test circuit designed to measure the settling time of the OP-285 is shown in Figure 7. This test method has advantages over false-sum node techniques in that the actual output of the amplifier is measured, instead of an error voltage at the sum node. Common-mode settling effects are exercised in this circuit in addition to the slew rate and bandwidth effects measured by the false-sum-node method. Of course, a reasonably flat-top pulse is required as the stimulus.

The output waveform of the OP-285 under test is clamped by Schottky diodes and buffered the JFET source follower. The signal is amplified by a factor of ten by the OP-260 and then Schottky-clamped at the output to prevent overloading the oscilloscope's input amplifier. The OP-41 is configured as a fast integrator which provides overall dc offset nulling.

## High Speed Operation

As with most high speed amplifiers, care should be taken with supply decoupling, lead dress, and component placement. Recommended circuit configurations for inverting and noninverting applications are shown in Figures 8 and Figure 9.


Figure 8. Unity Gain Follower


Figure 7. OP-285's Settling Time Test Fixture


Figure 9. Unity Gain Inverter

In inverting and noninverting applications, the feedback resistance forms a pole with the source resistance and capacitance ( $\mathrm{R}_{\mathrm{S}}$ and $\mathrm{C}_{\mathrm{S}}$ ) and the OP-285's input capacitance ( $\mathrm{C}_{\mathrm{IN}}$ ), as shown in Figure 10. With $R_{S}$ and $R_{F}$ in the kilohm range, this pole can create excess phase shift and even oscillation. A small capacitor, $\mathrm{C}_{\mathrm{FB}}$, in parallel with $\mathrm{R}_{\mathrm{FB}}$ eliminates this problem. By setting $\mathrm{R}_{\mathrm{S}}\left(\mathrm{C}_{\mathrm{S}}+\mathrm{C}_{\mathrm{IN}}\right)=\mathrm{R}_{\mathrm{FB}} \mathrm{C}_{\mathrm{FB}}$, the effect of the feedback pole is completely removed.


Figure 10. Compensating the Feedback Pole

## High Speed, Low Noise Differential Line Driver

The circuit of Figure 11 is a unique line driver widely used in industrial applications. With $\pm 18 \mathrm{~V}$ supplies, the line driver can deliver a differential signal of 30 V p-p into a $2.5 \mathrm{k} \Omega$ load. The high slew rate and wide bandwidth of the OP- 285 combine to yield a full power bandwidth of 130 kHz while the low noise front end produces a referred-to-input noise voltage spectral density of $10 \mathrm{nV} / \sqrt{\mathrm{Hz}}$. The design is a transformerless, balanced transmission system where output common-mode rejection of noise is of paramount importance. Like the transformerbased design, either output can be shorted to ground for unbalanced line driver applications without changing the circuit gain of 1 . Other circuit gains can be set according to the equation in the diagram. This allows the design to be easily set to noninverting, inverting, or differential operation.


Figure 11. High Speed, Low Noise Differential Line Driver

## Low Phase Error Amplifier

The simple amplifier configuration of Figure 12 utilizes the OP-285 and a few resistors to reduce phase error substantially over a wide frequency range when compared to conventional amplifier designs. This technique relies on the matched frequency characteristics of the two amplifiers in the OP-285. Each amplifier in the circuit has the same feedback network which produces a circuit gain of 10 . Since the two amplifiers are set to the same gain and are matched due to the monolithic construction of the OP-285, they will exhibit identical frequency response. Recall from feedback theory that a pole of a feedback network becomes a zero in the loop gain response. By using this technique, the dominant pole of the amplifier in the feedback loop compensates for the dominant pole of the main amplifier,


Figure 12. Active Feedback Allows Cancellation of A2's Dominant Pole by A1 Which Reduces the Phase Shift Significantly.
thereby reducing phase error dramatically. This is shown in Figure 13 where the $10 \times$ composite amplifier's phase response exhibits less than $1.5^{\circ}$ phase shift through 500 kHz . On the other hand, the single gain stage amplifier exhibits 25 degrees of phase shift over the same frequency range. An additional benefit of the low phase error configuration is constant group delay, by virtue of constant phase shift at all frequencies below 500 kHz . Although this technique is valid for minimum circuit gains of 10 , actual closed-loop magnitude response must be optimized for the amplifier chosen.


Figure 13. Phase Error Comparison

For a more detailed treatment on the design of low phase error amplifiers, please see Application Note AN-107.

## Fast Current Pump

A fast, $\pm 30 \mathrm{~mA}$ current source, illustrated in Figure 14, takes advantage of the OP-285's speed and high output current drive. This is a variation of the Howland current source where a second amplifier, A2, is used to increase load current accuracy and output voltage compliance. With supply voltages of $\pm 15 \mathrm{~V}$, the output voltage compliance of the current pump is $\pm 8 \mathrm{~V}$. To keep the output resistance in the $M \Omega$ range requires that $0.1 \%$ or better resistors be used in the circuit. The gain of the current pump can be easily changed according to the equations shown in the diagram.


Figure 14. A Fast Current Pump

## A Low Noise, High Speed Instrumentation Amplifier

A high speed, low noise instrumentation amplifier, constructed with a single OP-285, is illustrated in Figure 15. The circuit exhibits less than $1.2 \mu \mathrm{~V}$ p-p noise (RTI) in the 0.1 Hz to 10 Hz band and an input noise voltage spectral density of $9 \mathrm{nV} / \sqrt{\mathrm{Hz}}(1 \mathrm{kHz})$ at a gain of 1000 . The gain of the amplifier is easily set by $\mathrm{R}_{\mathrm{G}}$ according to the formula:

$$
\frac{V_{O U T}}{V_{I N}}=\frac{9.98 k \Omega}{R_{G}}+2
$$

The advantages of a two op amp instrumentation amplifier based on a dual op amp is that the errors in the individual amplifiers tend to cancel one another. For example, the circuit's input offset voltage is determined by the input offset voltage matching of the OP-285, which is typically less than $250 \mu \mathrm{~V}$.


Figure 15. A High Speed Instrumentation Amplifier

Common-mode rejection of the circuit is limited by the matching of resistors R1 to R4. For good common-mode rejection, these resistors ought to be matched to better than $1 \%$. The circuit was constructed with $1 \%$ resistors and included potentiometer P1 for trimming the DC CMRR and a capacitor C 1 for trimming the AC CMRR. With these two trims, the circuit's common-mode rejection was better than 95 dB at 60 Hz and better than 65 dB at 10 kHz . For the best common-mode rejection performance, use a matched (better than $0.1 \%$ ) thin-film resistor network for R1 through R4 and use the variable capacitor to optimize the circuit's AC CMR.
The instrumentation amplifier exhibits very wide small- and large-signal bandwidths regardless of the gain setting, as shown in the table. Because of its low noise, wide gain-bandwidth product, and high slew rate, the OP-285 is ideally suited for high speed signal conditioning applications.

| Circuit <br> Gain | $\mathbf{R}_{\mathbf{G}}$ | Circuit Bandwidth |  |
| :--- | :--- | :---: | :---: |
| $(\boldsymbol{\Omega})$ | $\mathbf{V}_{\text {OUT }}=\mathbf{1 0 0} \mathbf{m V} \mathbf{p - p}$ | $\mathbf{V}_{\text {OUT }}=\mathbf{2 0} \mathbf{V} \mathbf{p - p}$ |  |
| 2 | Open | 5 MHz | 780 kHz |
| 10 | 1.24 k | 1 MHz | 460 kHz |
| 100 | 102 | 90 kHz | 85 kHz |
| 1000 | 10 | 10 kHz | 10 kHz |



Figure 16. A 3-Pole, 40 kHz Low-Pass Filter

## A 3-Pole, 40 kHz Low-Pass Filter

The closely matched and uniform ac characteristics of the OP-285 make it ideal for use in GIC (Generalized Impedance Converter) and FDNR (Frequency-Dependent Negative Resistor) filter applications. The circuit in Figure 16 illustrates a linear-phase, 3-pole, 40 kHz low-pass filter using an OP-285 as an inductance simulator (gyrator). The circuit uses one OP-285 (A2 and A3) for the FDNR and one OP-285 (A1 and A4) as an input buffer and bias current source for A3. Amplifier A4 is configured in a gain of 2 to set the pass band magnitude response to 0 dB . The benefits of this filter topology over classical approaches are that the op amp used in the FDNR is not in the signal path and that the filter's performance is relatively insensitive to component variations. Also, the configuration is such that large signal levels can be handled without overloading any of the filter's internal nodes. As shown in Figure 17, the OP-285's symmetric slew rate and low distortion produce a clean, well-behaved transient response.


Figure 17. Low-Pass Filter Transient Response

## Driving Capacitive Loads

The OP-285 was designed to drive both resistive loads to $600 \Omega$ and capacitive loads of over 1000 pF and maintain stability. While there is a degradation in bandwidth when driving capacitive loads, the designer need not worry about device stability. The graph in Figure 18 shows the 0 dB bandwidth of the OP-285 with capacitive loads from 10 pF to 1000 pF .


Figure 18. Bandwidth vs. $C_{\text {LOAD }}$


*

* POLE AT 100 MHZ

R11 $2498 \quad 1$
$1.59 \mathrm{E}-9$
*
COMMON-MODE GAIN NETWORK WITH ZERO AT 1 kHZ *
R12 2526 1E6
R7 $2526 \quad 1.59 \mathrm{E}-12$
E2 $2598 \quad$ POLY(2) 19829802.5062 .506

* POLE AT 100 MHZ


Spice Diagram (A)


Spice Diagram (B)


## FEATURES

- Single/Dual Supply Operation
$\ldots . . . . .$.
$\ldots . . . . . . . \pm 0.8 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$
- True Single-Supply Operation; Input and Output Voltage Ranges Include Ground
- Low Supply Current (per amplifier) . . . . . . . . . . $20 \mu$ A Max
- High Output Drive . . . . . . . . . . . . . . . . . . . . . . . . . . . . 5mA Min
- Low Input Offset Voltage . . . . . . . . . . . . . . . . . . . . $200 \mu \mathrm{~V}$ Max
- High Open-Loop Gain . . . . . . . . . . . . . . . . . . . $700 \mathrm{~V} / \mathrm{mV}$ Min
- Outstanding PSRR
. $5.6 \mu \mathrm{~V} / \mathrm{V}$ Max
- Industry Standard 8-Pin Dual Pinout
- Available in Die Form


## ORDERING INFORMATION ${ }^{\dagger}$

| $\begin{gathered} \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ \mathrm{~V}_{\mathrm{OS}} \mathrm{MAX} \\ (\mathrm{mV}) \end{gathered}$ | PACKAGE |  |  | OPERATING TEMPERATURE RANGE |
| :---: | :---: | :---: | :---: | :---: |
|  | $\begin{aligned} & \text { CERDIP } \\ & 8 \text {-PIN } \end{aligned}$ | PLASTIC | $\frac{\text { LCC }}{20-\text { CONTACT }}$ |  |
| 200 | OP290AZ* | - | OP290ARC/883 | MIL |
| 200 | OP290EZ | - | - | XIND |
| 300 | OP290FZ | - | - | XIND |
| 500 | - | OP290GP | - | XIND |
| 500 | - | OP290GS ${ }^{\dagger \dagger}$ | - | XIND |

* For devices processed in total compliance to MIL-STD-883, add /883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.
$\dagger \dagger$ For availability and burn-in information on SO and PLCC packages, contact your local sales office.


## GENERAL DESCRIPTION

The OP-290 is a high performance micropower dual op amp that operates from a single supply of +1.6 V to +36 V or from

## PIN CONNECTIONS


dual supplies of $\pm 0.8 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$. Input voltage range includes the negative rail allowing the OP-290 to accommodate input signals down to ground in single supply operation. The OP-290's output swing also includes ground when operating from a single supply, enabling "zero-in, zero-out" operation.
The OP-290 draws less than $20 \mu \mathrm{~A}$ of quiescent supply current per amplifier, while able to deliver over 5 mA of output current to a load. Input offset voltage is below $200 \mu \mathrm{~V}$ eliminating the need for external nulling. Gain exceeds 700,000 and common-mode rejection is better than 100 dB . The power

Continued

SIMPLIFIED SCHEMATIC (One of two amplifiers is shown.)


This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

## GENERAL DESCRIPTION Continued

supply rejection ratio of under $5.6 \mu \mathrm{~V} / \mathrm{V}$ minimizes offset voltage changes experienced in battery powered systems.
The low offset voltage and high gain offered by the OP-290 bring precision performance to micropower applications. The minimal voltage and current requirements of the OP-290 suit it for battery and solar powered applications, such as portable instruments, remote sensors, and satellites. For a single op amp, see the OP-90; for a quad, see the OP-490.

## ABSOLUTE MAXIMUM RATINGS (Note 1)

Supply Voltage $\pm 18 \mathrm{~V}$
Differential input Voltage .............. [(V-)-20V] to $\left[\left(V_{+}\right)+20 \mathrm{~V}\right]$
Common-Mode Input Voltage
$[(\mathrm{V}-)-20 \mathrm{~V}]$ to $[(\mathrm{V}+)+20 \mathrm{~V}]$
Output Short-Circuit Duration Indefinite

## Storage Temperature Range

P, RC, S, Z Package .................................. $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

Operating Temperature Range

```
OP-290A
\(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
```

OP-290E, OP-290F, OP-290G .................... $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Junction Temperature ( $\mathrm{T}_{\mathrm{j}}$ ) ............................ $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature Range (Soldering, 60 sec ) ............... $300^{\circ} \mathrm{C}$

| PACKAGE TYPE | $\boldsymbol{\Theta}_{\text {IA }}$ (Note 2) | $\boldsymbol{\theta}_{\text {J }}$ | UNITS |
| :--- | :---: | :---: | :---: |
| 8 -Pin Hermetic DIP (Z) | 134 | 12 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin Plastic DIP (P) | 96 | 37 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 20-Contact LCC (RC) | 88 | 33 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $16-$ Pin SOL (S) | 92 | 27 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

NOTES:

1. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
2. $\Theta_{i A}$ is specified for worst case mounting conditions, i.e., $\Theta_{j A}$ is specified for device in socket for CerDIP, P-DIP, and LCC packages; $\Theta_{j A}$ is specified for device soldered to printed circuit board for SOL package.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 1.5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-290A/E |  |  | OP-290F |  |  | OP-290G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Input Offset Voltage | $\mathrm{V}_{\mathrm{OS}}$ |  | - | 50 | 200 | - | 75 | 300 | - | 125 | 500 | $\mu \stackrel{\rightharpoonup}{\mathrm{V}}$ |
| Input Offset Current | Ios | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 0.1 | 3 | - | 0.1 | 5 | - | 0.1 | 5 | nA |
| Input Bias Current | $\mathrm{I}_{B}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 4.0 | 15 | - | 4.0 | 20 | - | 4.0 | 25 | nA |
| Large Signal Voltage Gain | Avo | $\begin{aligned} & V_{S}= \pm 15 \mathrm{~V}, \mathrm{~V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \\ & R_{\mathrm{L}}=100 \mathrm{k} \Omega \\ & R_{\mathrm{L}}=10 \mathrm{k} \Omega \\ & R_{\mathrm{L}}=2 \mathrm{k} \Omega \end{aligned}$ | $\begin{aligned} & 700 \\ & 350 \\ & 125 \\ & \hline \end{aligned}$ | 1200 600 250 | - | 500 250 100 | 1000 500 200 | - | 400 200 100 | 800 400 200 | - - - |  |
|  |  | $\begin{gathered} \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V}, \\ 1 \mathrm{~V}<\mathrm{V}_{\mathrm{O}}<4 \mathrm{~V} \\ R_{\mathrm{L}}=100 \mathrm{k} \Omega \\ \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \end{gathered}$ | $\begin{aligned} & 200 \\ & 100 \end{aligned}$ | $\begin{aligned} & 400 \\ & 180 \end{aligned}$ | - | $\begin{array}{r} 125 \\ 75 \\ \hline \end{array}$ | 300 140 | - | 100 70 | 250 140 | - |  |
| Input Voltage Range | IVR | $\begin{aligned} & \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V} \quad \text { (Note 1) } \end{aligned}$ | $\begin{array}{r} 0 / 4 \\ -15 / 13.5 \end{array}$ | $-$ | - | $\begin{array}{r} 0 / 4 \\ -15 / 13.5 \\ \hline \end{array}$ | - | - | $\begin{array}{r} 0 / 4 \\ -15 / 13.5 \\ \hline \end{array}$ | - | - | V |
| Output Voltage Swing | $\mathrm{V}_{\mathrm{O}}$ | $\begin{gathered} V_{S}= \pm 15 \mathrm{~V} \\ R_{L}=10 \mathrm{k} \Omega \\ R_{L}=2 \mathrm{k} \Omega \end{gathered}$ | $\begin{array}{r}  \pm 13.5 \\ \pm 10.5 \end{array}$ | $\begin{gathered} \pm 14.2 \\ \pm 11.5 \end{gathered}$ | - | $\begin{aligned} & \pm 13.5 \\ & \pm 10.5 \end{aligned}$ | $\begin{array}{r}  \pm 14.2 \\ \pm 11.5 \end{array}$ | - | $\begin{aligned} & \pm 13.5 \\ & \pm 10.5 \\ & \hline \end{aligned}$ | $\begin{array}{r}  \pm 14.2 \\ \pm 11.5 \\ \hline \end{array}$ | - | V |
|  | $\mathrm{V}_{\mathrm{OH}}$ | $\begin{gathered} \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V} \\ \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \end{gathered}$ | 4.0 | 4.2 | - | 4.0 | 4.2 | - | 4.0 | 4.2 | - | V |
|  | $\mathrm{V}_{\mathrm{OL}}$ | $\begin{aligned} & V+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V} \\ & R_{\mathrm{L}}=10 \mathrm{k} \Omega \end{aligned}$ | - | 10 | 50 | - | 10 | 50 | - | 10 | 50 | $\mu \mathrm{V}$ |
| Common-Mode Rejection | CMR | $\begin{aligned} & \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V}, \\ & 0 \mathrm{~V}<\mathrm{V}_{\mathrm{CM}}<4 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V} \\ & -15 \mathrm{~V}<\mathrm{V}_{\mathrm{CM}}<13.5 \mathrm{~V} \end{aligned}$ | 90 100 | $\begin{aligned} & 115 \\ & 120 \end{aligned}$ | - - | 80 90 | 100 120 | - - | 80 90 | 100 120 | - - | dB |
| Power Supply Rejection Ratio | PSRR |  | - | 1.0 | 5.6 | - | 1.0 | 5.6 | - | 3.2 | 10 | $\mu \mathrm{V} / \mathrm{V}$ |
| Supply Current (All Amplifiers) | Isy | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}= \pm 1.5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V} \end{aligned}$ | - | 19 25 | 30 40 | - | 19 25 | 30 40 | - | 19 25 | 30 40 | $\mu \mathrm{A}$ |
| Capacitive Load Stability |  | $A_{V}=+1$ <br> No Oscillations | - | 650 | - | - | 650 | - | - | 650 | - | pF. |
| Input Noise Voltage | $e_{n p-p}$ | $\begin{aligned} & \mathrm{f}_{\mathrm{O}}=0.1 \mathrm{~Hz} \text { to } 10 \mathrm{~Hz} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V} \end{aligned}$ | - | 3 | - | - | 3 | - | - | 3 | - | $\mu \mathrm{V}_{\mathrm{p}-\mathrm{p}}$ |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 1.5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted. Continued

|  |  |  | OP-290A/E |  |  | OP-290F |  |  | OP-290G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX. |  |
| Input Resistance Differential-Mode | $\mathrm{R}_{\text {IN }}$ | $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}$ | - | 30 | - | - | 30 | - | - | 30 | - | M $\Omega$ |
| Input Resistance Common-Mode | $\mathrm{R}_{\text {INCN }}$ | $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}$ | - | 20 | - | - | 20 | - | - | 20 | - | G $\Omega$ |
| Slew Rate | SR | $\begin{aligned} & A_{V}=+1 \\ & V_{S}= \pm 15 \mathrm{~V} \end{aligned}$ | 5 | 12 | - | 5 | 12 | - | 5 | 12 | - | $\mathrm{V} / \mathrm{ms}$ |
| Gain Bandwidth Product | GBWP | $\begin{aligned} & A_{V}=+1 \\ & V_{S}= \pm 15 \mathrm{~V} \end{aligned}$ | - | 20 | - | - | 20 | - | - | 20 | - | kHz |
| Channel Separation | CS | $\begin{aligned} & f_{O}=10 \mathrm{~Hz} \\ & V_{O}=20 V_{p-p} \\ & V_{S}= \pm 15 \mathrm{~V} \text { (Note 2) } \end{aligned}$ | 120 | 150 | - | 120 | 150 | - | 120 | 150 | - | dB |

NOTES:

1. Guaranteed by CMR test
2. Guaranteed but not $100 \%$ tested.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 1.5 \mathrm{~V}$ to $\pm 15 \mathrm{~V},-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq 125^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-290A |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX |  |
| Input Offset Voltage | $v_{\text {OS }}$ |  | - | 80 | 500 | $\mu \mathrm{V}$ |
| Average Input Offset Voltage Drift | TCV ${ }_{\text {os }}$ | $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}$ | - | 0.3 | 3 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current | los | $\mathrm{V}_{C M}=0 \mathrm{~V}$ | - | 0.1 | 5 | nA |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ | $\mathrm{V}_{C M}=0 \mathrm{~V}$ | - | 4.2 | 20 | nA |
| Large Signal Voltage Gain | Avo | $\begin{aligned} & V_{S}= \pm 15 \mathrm{~V}, \mathrm{~V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \\ & R_{\mathrm{L}}=100 \mathrm{k} \Omega \\ & R_{\mathrm{L}}=10 \mathrm{k} \Omega \\ & R_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & \hline \end{aligned}$ | $\begin{array}{r} 225 \\ 125 \\ 50 \\ \hline \end{array}$ | $\begin{aligned} & 400 \\ & 240 \\ & 110 \\ & \hline \end{aligned}$ | - | V/mV |
|  |  | $\begin{gathered} \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V}, \\ \mathrm{~V}<\mathrm{V}_{\mathrm{O}}<4 \mathrm{~V} \\ \mathrm{R}_{\mathrm{L}}=100 \mathrm{k} \Omega \\ \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \end{gathered}$ | $\begin{array}{r} 100 \\ 50 \\ \hline \end{array}$ | $\begin{array}{r}200 \\ 110 \\ \hline\end{array}$ | - |  |
| Input Voitage Range | IVR | $\begin{aligned} & \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V} \quad \text { (Note 1) } \\ & \mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V} \end{aligned}$ | $\begin{array}{r} 0 / 3.5 \\ -15 / 13.5 \\ \hline \end{array}$ | - | - | V |
| Output Voltage Swing | $\mathrm{v}_{0}$ | $\begin{aligned} & \mathrm{V}_{S}= \pm 15 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & \hline \end{aligned}$ | $\begin{array}{r}  \pm 13 \\ \pm 10 \\ \hline \end{array}$ | $\begin{array}{r}  \pm 14.1 \\ \pm 11 \\ \hline \end{array}$ | - | v |
|  | $\mathrm{V}_{\mathrm{OH}}$ | $\begin{gathered} \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V} \\ \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \end{gathered}$ | 3.9 | 4.1 | - | v |
|  | $\mathrm{V}_{\mathrm{OL}}$ | $\begin{gathered} \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V} \\ \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \end{gathered}$ | - | 10 | 100 | $\mu \mathrm{V}$ |
| Common-Mode Rejection | CMR | $\begin{aligned} & \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V}, 0 \mathrm{~V}<\mathrm{V}_{\mathrm{CM}}<3.5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V},-15 \mathrm{~V}<\mathrm{V}_{\mathrm{CM}}<13.5 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 80 \\ & 90 \\ & \hline \end{aligned}$ | $\begin{aligned} & 105 \\ & 115 \end{aligned}$ | - | dB |
| Power Supply <br> Rejection Ratio | PSRR |  | - | 3.2 | 10 | $\mu \mathrm{V} / \mathrm{V}$ |
| Supply Current (All Amplifiers) | $\mathrm{I}_{\text {SY }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}= \pm 1.5 \mathrm{~V} \\ & \mathrm{v}_{\mathrm{S}}= \pm 15 \mathrm{~V} \\ & \hline \end{aligned}$ | - | 30 38 | 50 60 | $\mu \mathrm{A}$ |

## NOTE:

1. Guaranteed by CMR test.

ELECTRICAL CHARACTERISTICS at $V_{S}= \pm 1.5 \mathrm{~V}$ to $\pm 15 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq 85^{\circ} \mathrm{C}$ for OP-290E/F/G, unless otherwise noted.

| PARAMETER |  |  | OP-290E |  |  | OP-290F |  |  | OP-290G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | SYMBOL | CONDITIONS | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Input Offset Voltage | $\mathrm{V}_{\text {OS }}$ |  | - | 70 | 400 | - | 115 | 600 | - | 200 | 750 | $\mu \mathrm{V}$ |
| Average Input Offset Voltage Drift | $\mathrm{TCV}_{\text {OS }}$ | $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}$ | - | 0.3 | 3 | - | 0.6 | 5 | - | 1.2 | - | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current | los | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 0.1 | 3 | - | 0.1 | 5 | - | 0.1 | 7 | nA |
| Input Bias Current | $\mathrm{I}_{B}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 4.2 | 15 | - | 4.2 | 20 | - | 4.2 | 25 | nA |
| Large Signal Voltage Gain | $A_{\text {vo }}$ | $\begin{aligned} V_{S} & = \pm 15 \mathrm{~V}, V_{O}= \pm 10 \mathrm{~V} \\ R_{L} & =100 \mathrm{k} \Omega \\ R_{L} & =10 \mathrm{k} \Omega \\ R_{L} & =2 \mathrm{k} \Omega \end{aligned}$ | $\begin{aligned} & 500 \\ & 250 \\ & 100 \end{aligned}$ | $\begin{array}{r} 800 \\ 400 \\ 200 \\ \hline \end{array}$ | - | 350 175 75 | 700 350 150 | - | 300 150 75 | $\begin{array}{r} 600 \\ 250 \\ 125 \\ \hline \end{array}$ | - | $\mathrm{V} / \mathrm{mV}$ |
|  |  | $\begin{gathered} \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V}, \\ 1 \mathrm{~V}<\mathrm{V},<4 \mathrm{~V} \\ R_{\mathrm{L}}=100 \mathrm{k} \Omega \\ \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \end{gathered}$ | $\begin{array}{r} 150 \\ 75 \end{array}$ | 280 140 | - | 100 50 | 220 110 | - | 80 40 | 160 90 | - |  |
| Input Voltage Range | IVR | $\begin{aligned} & \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V} \quad(\text { Note } 1) \end{aligned}$ | $\begin{array}{r} 0 / 3.5 \\ -15 / 13.5 \\ \hline \end{array}$ | - | - | $\begin{array}{r} 0 / 3.5 \\ -15 / 13.5 \\ \hline \end{array}$ | - | - | $\begin{array}{r} 0 / 3.5 \\ -15 / 13.5 \\ \hline \end{array}$ | - | - | V |
| Output Voltage Swing | $\mathrm{V}_{0}$ | $\begin{gathered} V_{S}= \pm 15 \mathrm{~V} \\ R_{\mathrm{L}}=10 \mathrm{k} \Omega \\ R_{\mathrm{L}}=2 \mathrm{k} \Omega \end{gathered}$ | $\begin{aligned} & \pm 13 \\ & \pm 10 \end{aligned}$ | $\pm 14$ $\pm 11$ | - | $\pm 13$ $\pm 10$ | $\pm 14$ $\pm 11$ | - | $\pm 13$ $\pm 10$ | $\begin{aligned} & \pm 14 \\ & \pm 11 \end{aligned}$ | - | V |
|  | $\mathrm{V}_{\mathrm{OH}}$ | $\begin{gathered} \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V} \\ \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \end{gathered}$ | 3.9 | 4.1 | - | 3.9 | 4.1 | - | 3.9 | 4.1 | - | V |
|  | $\mathrm{V}_{\mathrm{OL}}$ | $\begin{gathered} \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V} \\ \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \end{gathered}$ | - | 10 | 100 | - | 10 | 100 | - | 10 | 100 | $\mu \mathrm{V}$ |
| Common-Mode Rejection | CMR | $\begin{aligned} & V+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V}, \\ & 0 \mathrm{~V}<\mathrm{V}_{\mathrm{CM}}<3.5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \\ & -15 \mathrm{~V}<V_{C M}<13.5 \mathrm{~V} \end{aligned}$ | 85 95 | 105 115 | - - | 80 90 | 100 110 | - | 80 90 | 100 110 | - | dB |
| Power Supply <br> Rejection Ratio | PSRR |  | - | 3.2 | 7.5 | - | 5.6 | 10 | - | 5.6 | 15 | $\mu \mathrm{V} / \mathrm{V}$ |
| Supply Current <br> (All Amplifiers) | $\mathrm{I}_{\text {SY }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}= \pm 1.5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V} \end{aligned}$ | - | $\begin{aligned} & 24 \\ & 31 \end{aligned}$ | 50 60 | - | 24 31 | 50 60 | - | 24 31 | 50 60 | $\mu \mathrm{A}$ |

## NOTE:

1. Guaranteed by CMR test.

## FEATURES

Single-Supply Operation: 2.7 V to 12 V
Wide Input Voltage Range
Rail-to-Rail Output Swing
Low Supply Current: $300 \mu \mathrm{~A} /$ Amp
Wide Bandwidth: 3 MHz
Slew Rate: $0.5 \mathrm{~V} / \mu \mathrm{s}$
Low Offset Voltage: $700 \mu \mathrm{~V}$
No Phase Reversal
Drives Capacitive Loads

## APPLICATIONS

Industrial Process Control
Battery Powered Instrumentation
Power Supply Control and Protection

## Telecom

Remote Sensors
Low Voltage Strain Gage Amplifiers
DAC Output Amplifier

## GENERAL DESCRIPTION

The OP291 and OP491 are dual and quad micropower singlesupply, 3 MHz bandwidth amplifiers featuring rail-to-rail inputs and outputs. The OP291 and OP491 are guaranteed to operate from a 3 volt single supply as well as $\pm 5$ volt dual supplies.

Fabricated on Analog Devices' CBCMOS process, the OP291/ OP491 have a unique input stage that allows the input voltage to safely extend 10 volts beyond either supply without any phase inversion or latch-up. The output voltage swings to within millivolts of the supplies and continues to sink or source current all the way to the supplies.
Applications for these amplifiers include portable telecom equipment, power supply control and protection, and interface for transducers with wide output ranges. Sensors requiring a rail-to-rail input amplifier include Hall effect, piezo electric, and resistive transducers.

The ability to swing rail-to-rail at both the input and output enables designers to build multistage filters in single-supply systems and maintain high signal-to-noise ratios.
The OP291/OP491 are specified over the extended industrial $\left(-40^{\circ} \mathrm{C}\right.$ to $\left.+125^{\circ} \mathrm{C}\right)$ temperature range. The OP291 dual amplifiers are available in 8 -pin plastic DIPs and SO surface mount packages. The OP491 quad is available in 14-pin DIPs and 14 -pin SO packages.

## PIN CONFIGURATIONS

8-Lead Epoxy DIP
(P Suffix)


14-Lead Epoxy DIP (P Suffix)



Figure 1. Input and Output with Inputs Overdriven by 5 V

## OP291/OP491-SPECIFICATIONS




[^194]ELECTRICAL SPECIFICATIONS ( $@ \mathrm{~V}_{\mathrm{s}}=+5.0 \mathrm{v}, \mathrm{v}_{\mathrm{ch}}=0.05 \mathrm{v}, \mathrm{v}_{0}=1.4 \mathrm{v}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)


[^195]
## ELECTRICAL SPECIFICATIONS $\left(@ v_{0}= \pm 5.0 \mathrm{v}, \mathrm{v}_{\mathrm{CM}}=0 \mathrm{v}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right.$ unless otherwise noted)



Specifications subject to change without notice.

WAFER TEST LIMITS (@ $V_{S}=+3.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)

| Parameter | Symbol | Conditions | Limit | Units |
| :---: | :---: | :---: | :---: | :---: |
| Offset Voltage | $\mathrm{V}_{\text {OS }}$ |  | $\pm 300$ | $\mu \mathrm{V}$ max |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ |  | 50 | $n A$ max |
| Input Offset Current | $\mathrm{I}_{\mathrm{OS}}$ |  | 8 | nA |
| Input Voltage Range | $\mathrm{V}_{\mathrm{CM}}$ |  | V - to $\mathrm{V}+$ | $V$ min |
| Common-Mode Rejection Ratio | CMRR | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ to 10 V | 70 | dB min |
| Power Supply Rejection Ratio | PSRR | $\mathrm{V}=2.7 \mathrm{~V}$ to +12 V | 80 | dB min |
| Large Signal Voltage Gain | $\mathrm{A}_{\text {vo }}$ | $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ | 25 | $\mathrm{V} / \mathrm{mV}$ min |
| Output Voltage High | $\mathrm{V}_{\mathrm{OH}}$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ to GND | 2.8 | V min |
| Output Voltage Low | $\mathrm{V}_{\text {OL }}$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ to $\mathrm{V}+$ | 55 | mV max |
| Supply Current/Amplifier | $\mathrm{I}_{\text {SY }}$ | $\mathrm{V}_{\mathrm{O}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=\infty$ | 350 | $\mu \mathrm{A}$ max |

NOTE
Electrical tests and wafer probe to the limits shown. Due to variations in assembly methods and normal yield loss, yield after packaging is not guaranteed for standard product dice. Consult factory to negotiate specifications based on dice lot qualifications through sample lot assembly and testing.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

| Supply Voltage | V |
| :---: | :---: |
| Input Voltage | V - to $\mathrm{V}+10 \mathrm{~V}$ |
| Differential Input Voltage | 7 V |
| Output Short-Circuit Duration to GND | Indefinite |
| Storage Temperature Range |  |
| P, S Packages | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Operating Temperature Range |  |
| OP291/OP491G | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Junction Temperature Range |  |
| P, S Packages | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Lead Temperature Range (Soldering 60 se | $+300^{\circ} \mathrm{C}$ |


| Package Type | $\theta_{\text {JA }}{ }^{2}$ | $\theta_{\text {JC }}$ | Units |
| :--- | :--- | :--- | :--- |
| 8-Pin Plastic DIP (P) | 103 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin SOIC (S) | 158 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 14-Pin Plastic DIP (P) | 76 | 33 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 14-Pin SOIC (S) | 120 | 36 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

NOTES
${ }^{1}$ Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
${ }^{2} \theta_{\mathrm{JA}}$ is specified for the worst case conditions; i.e., $\theta_{\mathrm{JA}}$ is specified for device in socket for P-DIP packages, $\theta_{\mathrm{JA}}$ is specified for device soldered in circuit board for SOIC package.

## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| OP291GP | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | N-8 |
| OP291GS | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin SOIC | SO-8 |
| OP291GBC | $+25^{\circ} \mathrm{C}$ | DICE | N-14 |
| OP491GP | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 14-Pin Plastic DIP | N-Pin SOIC |
| OP491GS | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 14-Pin |  |
| OP491GBC | $+25^{\circ} \mathrm{C}$ | DICE |  |

[^196]
## DICE CHARACTERISTICS



OP291 Die Size $0.070 \times 0.070$ Inch, 4,900 Sq. Mils. Substrate (Die Backside) Is Connected to V+. Transistor Count, 146.


OP491 Die Size $0.070 \times 0.110$ Inch, 7,700 Sq. Mils. Substrate (Die Backside) Is Connected to V+. Transistor Count, 290.

## OP291/OP491-Typical Performance Characteristics



Figure 2. OP291 Input Offset Voltage Distribution, $V_{s}=+3 \mathrm{~V}$


Figure 5. OP291/OP491 Input Bias Current vs. Temperature, $V_{S}=+3 V$


Figure 3. OP291 Input Offset Voltage Drift Distribution, $V_{S}=+3 \mathrm{~V}$


Figure 6. OP291/OP491 Input Offset Current vs.Temperature, $V_{s}=+3 \mathrm{~V}$


Figure 9. OP291/OP491 Open-Loop Gain \& Phase vs. Frequency, $V_{S}=+3 . V$


Figure 4. OP291/OP491 Input Offset Voltage vs. Temperature, $V_{S}=+3 V$


Figure 7. OP291/OP491 Input Bias Current vs. Common-Mode Voltage, $V_{s}=+3 \mathrm{~V}$


Figure 10. OP291/OP491 Open-Loop Gain vs. Temperature, $V_{s}=+3 \mathrm{~V}$


Figure 11. OP291/OP491 Closed-Loop Gain vs. Frequency, $V_{s}=+3 \mathrm{~V}$


Figure 14. OP291/OP491 PSRR vs.
Frequency, $V_{S}=+3 \mathrm{~V}$


Figure 17. OP291/OP491 Supply Current vs. Temperature, $V_{S}=+3 V$, $+5 V, \pm 5 \mathrm{~V}$


Figure 12. OP291/OP491 CMRR vs. Frequency, $V_{S}=+3 V$


Figure 15. OP291/OP491 PSRR vs. Temperature, $V_{S}=+3 \mathrm{~V}$


Figure 18. Maximum Output Swing vs. Frequency, $V_{S}=+3 \mathrm{~V}$


Figure 13. OP291/OP491 CMRR vs. Temperature, $V_{S}=+3 \mathrm{~V}$


Figure 16. OP291/OP491 Slew Rate vs. Temperature, $V_{S}=+3 \mathrm{~V}$


Figure 19. OP291/OP491 Voltage Noise Density

## OP291/OP491-Typical Performance Characteristics



Figure 20. OP291 Input Offset Voltage Distribution, $V_{s}=+5 \mathrm{~V}$


Figure 23. OP291/OP491 Input Bias Current vs. Temperature, $V_{S}=+5 \mathrm{~V}$


Figure 26. OP291/491 Output Voltage Swing vs. Temperature, $V_{S}=+5 \mathrm{~V}$


Figure 21. OP291 Input Offset Voltage Drift Distribution, $V_{s}=+5 \mathrm{~V}$


Figure 24. OP291/OP491 Input Offset Current vs. Temperature, $V_{s}=+5 \mathrm{~V}$


Figure 27. OP291/491 Open-Loop Gain \& Phase vs. Frequency, $V_{S}=+5 \mathrm{~V}$


Figure 22. OP291/OP491 Input Offset Voltage vs. Temperature, $V_{S}=+5 \mathrm{~V}$


Figure 25. OP291/OP491 Input Bias Current vs. Common-Mode Voltage, $V_{S}=+5 \mathrm{~V}$


Figure 28. OP291/491 Open-Loop Gain vs. Temperature, $V_{S}=+5 \mathrm{~V}$


Figure 29. OP291/OP491 Closed-Loop Gain vs. Frequency, $V_{S}=+5 \mathrm{~V}$


Figure 32. OP291/OP491 PSRR vs.
Frequency, $V_{S}=+5 \mathrm{~V}$


Figure 35. OP291/OP491 Short Circuit Current vs. Temperature, $V_{S}=+3 V$, $+5 \mathrm{~V}, \pm 5 \mathrm{~V}$


Figure 30. OP291/OP491 CMRR vs.
Frequency, $V_{S}=+5 \mathrm{~V}$


Figure 33. OP291 Slew Rate vs. Temperature, $V_{S}=+5 \mathrm{~V}$


Figure 36. OP291/OP491 Channel Separation, $V_{S}= \pm 5 \mathrm{~V}$


Figure 31. OP291/OP491 CMRR vs. Temperature, $V_{S}=+5 \mathrm{~V}$


Figure 34. OP491 Slew Rate vs. Temperature, $V_{S}=+5 \mathrm{~V}$


Figure 37. Maximum Output Swing vs. Frequency, $V_{s}= \pm 5 \mathrm{~V}$

## OP291/OP491-Typical Performance Characteristics



Figure 38. Maximum Output Swing vs. Frequency, $V_{s}= \pm 5 \mathrm{~V}$


Figure 41. OP291/OP491 Input Offset Current vs. Temperature, $V_{S}= \pm 5 \mathrm{~V}$


Figure 44. OP291/OP491 Open-Loop Gain \& Phase vs. Frequency, $V_{S}= \pm 5 \mathrm{~V}$


Figure 39. OP291/OP491 Input Offset Voltage vs. Temperature, $V_{S}= \pm 5 \mathrm{~V}$


Figure 42. OP291/OP491 Input Bias Current vs. Common-Mode Voltage, $V_{S}= \pm 5 \mathrm{~V}$


Figure 45. OP291/OP491 Open-Loop Gain vs. Temperature, $V_{s}= \pm 5 \mathrm{~V}$


Figure 40. OP291/OP491 Input Bias Current vs. Temperature, $V_{S}= \pm 5 \mathrm{~V}$


Figure 43. OP291/OP491 Output Voltage Swing vs. Temperature, $V_{S}= \pm 5 V$


Figure 46. OP291/OP491 Closed-Loop Gain vs. Frequency, $V_{s}= \pm 5$ V


Figure 47. OP291/OP491 CMRR vs.
Frequency, $V_{S}= \pm 5 \mathrm{~V}$


Figure 50. OP291/OP491 PSRR vs.
Temperature, $V_{S}= \pm 5 \mathrm{~V}$


Figure 48. OP291/OP491 CMRR vs. Temperature, $V_{S}= \pm 5 \mathrm{~V}$


Figure 51. OP291/OP491 Slew Rate vs. Temperature, $V_{S}= \pm 5 \mathrm{~V}$


Figure 49. OP291/OP491 PSRR vs. Frequency, $V_{s}= \pm 5 \mathrm{~V}$


Figure 52. OP291/OP491 Output Impedance vs. Frequency


Figure 53. OP291/OP491 Large Signal
Transient Response, $V_{S}=+3 \mathrm{~V}$


Figure 54. OP291/OP491 Large Signal Transient Response, $V_{S}= \pm 5 \mathrm{~V}$

## OP291/0P491

## FUNCTIONAL DESCRIPTION

The OP291 and OP491 are single supply, micropower amplifiers featuring rail-to-rail inputs and outputs. In order to achieve wide input and output ranges, these amplifiers employ unique input and output stages. As the simplified schematic shows (Figure 55), the input stage is actually comprised of two differential pairs, a PNP pair and an NPN pair. These two stages do not actually work in parallel. Instead, only one or the other stage is on for any given input signal level. The PNP stage (transistors Q1 and Q2) is required to ensure that the amplifier remains in the linear region when the input voltage approaches and reaches the negative rail. On the other hand, the NPN stage (transistors Q5 and Q6) is needed for input voltages up to and including the positive rail.

For the majority of the input common-mode range, the PNP stage is active, as is evidenced by examining the graph of Input Bias Current vs. Common-Mode Voltage. Notice that the bias current switches direction at approximately 1.2 volts to 1.3 volts below the positive rail. At voltages below this, the bias current flows out of the OP291, indicating a PNP input stage. Above this voltage, however, the bias current enters the device, revealing the NPN stage. The actual mechanism within the amplifier for switching between the input stages is comprised of the transistors $\mathrm{Q} 3, \mathrm{Q} 4$, and Q 7 . As the input common-mode voltage increases, the emitters of Q1 and Q2 follow that voltage plus a diode drop. Eventually the emitters of Q1 and Q2 are high enough to turn Q3 on. This diverts the $8 \mu \mathrm{~A}$ of tail current away from the PNP input stage, turning it off. Instead, the current is mirrored through Q4 and Q7 to activate the NPN input stage.
Notice that the input stage includes $5 \mathrm{k} \Omega$ series resistors and differential diodes, a common practice in bipolar amplifiers to protect the input transistors from large differential voltages. These diodes will turn on whenever the differential voltage
exceeds approximately 0.6 V . In this condition, current will flow between the input pins, limited only by the two $5 \mathrm{k} \Omega$ resistors. Being aware of this characteristic is important in circuits where the amplifier may be operated open-loop, such as a comparator. Evaluate each circuit carefully to make sure that the increase in current does not affect the performance.
The output stage of the OP291/OP491 uses a PNP and an NPN transistor as do most output stages; however, the output transistors, Q32 and Q33, are actually connected with their collectors to the output pin to achieve the rail-to-rail output swing. As the output voltage approaches either the positive or negative rail, these transistors begin to saturate. Thus, the final limit on output voltage is the saturation voltage of these transistors, which is about 50 mV . The output stage does have inherent gain arising from the collectors and any external load impedance. Because of this, the open-loop gain of the amplifier is dependent on the load resistance.

## Input Overvoltage Protection

As with any semiconductor device, whenever the condition exists for the input to exceed either supply voltage, attention needs to be paid to the input overvoltage characteristic. When an overvoltage occurs, the amplifier could be damaged depending on the voltage level and the magnitude of the fault current. Figure 56 shows the characteristic for the OP291 and OP491. This graph was generated with the power supplies at ground and a curve tracer connected to the input. As can be seen, when the input voltage exceeds either supply by more than 0.6 V , internal pn-junctions energize allowing current to flow from the input to the supplies. As described above, the OP291/OP491 does have $5 \mathrm{k} \Omega$ resistors in series with each input, which helps limit the current. Calculating the slope of the current versus voltage in the graph confirms the $5 \mathrm{k} \Omega$ resistor.


Figure 55. OP291/OP491 Simplified Schematic


Figure 56. Input Overvoltage Characteristics
This input current is not inherently damaging to the device as long as it is limited to 5 mA or less. In the case shown, for an input of 10 V over the supply, the current is limited to 1.8 mA . If the voltage is large enough to cause more than 5 mA of current to flow, then an external series resistor should be added. The size of this resistor is calculated by dividing the maximum overvoltage by 5 mA and subtracting the internal $5 \mathrm{k} \Omega$ resistor. For example, if the input voltage could reach 100 V , the external resistor should be $(100 \mathrm{~V} / 5 \mathrm{~mA})-5 \mathrm{k}=15 \mathrm{k} \Omega$. This resistance should be placed in series with either or both inputs if they are subjected to the overvoltages. For more information on general overvoltage characteristics of amplifiers refer to the 1993 System Applications Guide, available from the Analog Devices Literature Center.

## Output Voltage Phase Reversal

Some operational amplifiers designed for single-supply operation exhibit an output voltage phase reversal when their inputs are driven beyond their useful common-mode range. Typically for single-supply bipolar op amps, the negative supply deter-
mines the lower limit of their common-mode range. With these devices, external clamping diodes, with the anode connected to ground and the cathode to the inputs, prevent input signal excursions from exceeding the device's negative supply (i.e., GND), preventing a condition which could cause the output voltage to change phase. JFET-input amplifiers may also exhibit phase reversal, and, if so, a series input resistor is usually required to prevent it.
The OP291/OP491 is free from reasonable input voltage range restrictions due to its novel input structure. In fact, the input signal can exceed the supply voltage by a significant amount without causing damage to the device. As illustrated in Figure 57, the OP291/OP491 can safely handle a 20 V p-p input signal on $\pm 5 \mathrm{~V}$ supplies without exhibiting any sign of output voltage phase reversal or other anomalous behavior. Thus no external clamping diodes are required.

## Overdrive Recovery

The overdrive recovery time of an operational amplifier is the time required for the output voltage to recover to its linear region from a saturated condition. This recovery time is important in applications where the amplifier must recover quickly after a large transient event, such as a comparator. The circuit shown in Figure 58 was used to evaluate the OP291/ OP491's overload recovery time. The OP291/OP491 takes approximately $8 \mu$ s to recover from positive saturation and approximately $6.5 \mu$ s to recover from negative saturation.


Figure 58. Overdrive Recovery Time Test Circuit


Figure 57. OP291/OP491 Output Voltage Phase Reversal Behavior

## OP291/OP491

## APPLICATIONS

## Single +3 V Supply, Instrumentation Amplifier

The OP291's low supply current and low voltage operation make it ideal for battery powered applications such as the instrumentation amplifier shown in Figure 59. The circuit utilizes the classic two op amp instrumentation amplifier topology, with four resistors to set the gain. The equation is simply that of a noninverting amplifier as shown in the figure. The two resistors labeled R1 should be closely matched to each other as well as both resistors labeled R2 to ensure good common-mode rejection performance. Resistor networks ensure the closest matching as well as matched drifts for good temperature stability. Capacitor C 1 is included to limit the bandwidth and, therefore, the noise in sensitive applications. The value of this capacitor should be adjusted depending on the desired closed-loop bandwidth of the instrumentation amplifier. The RC combination creates a pole at a frequency equal to $1 /(2 \pi \times \mathrm{R} 1 \mathrm{Cl})$. If AC-CMRR is critical, than a matched capacitor to C 1 should be included across the second resistor labeled R1.


Figure 59. Single +3 V Supply Instrumentation Amplifier
Because the OP291 accepts rail-to-rail inputs, the input common-mode range includes both ground and the positive supply of 3 V . Furthermore, the rail-to-rail output range ensures the widest signal range possible and maximizes the dynamic range of the system. Also, with its low supply current of $300 \mu \mathrm{~A} /$ device, this circuit consumes a quiescent current of only $600 \mu \mathrm{~A}$, yet still exhibits a gain bandwidth of 3 MHz .
A question may arise about other instrumentation amplifier topologies for single supply applications. For example, a variation on this topology adds a fifth resistor between the two inverting inputs of the op amps for gain setting. While that topology works well in dual supply applications, it is inherently not appropriate for single supply circuits. The same could be said for the traditional three op amp instrumentation amplifier. In both cases, the circuits simply will not work in single supply situations unless a false ground between the supplies is created.

## Single Supply RTD Amplifier

The circuit in Figure 60. uses three op amps of the OP491 to develop a bridge configuration for an RTD amplifier that operates from a single +5 V supply. The circuit takes advantage of the OP491's wide output swing range to generate a high bridge excitation voltage of 3.9 V . In fact, because of the rail-to-rail output swing, this circuit will work with supplies as low as 4.0 V . Amplifier A1 servos the bridge to create a constant excitation current in conjunction with the AD589, a 1.235 V precision reference. The op amp maintains the reference voltage across the parallel combination of the $6.19 \mathrm{k} \Omega$ and 2.55 $\mathrm{M} \Omega$ resistor, which generates a $200 \mu \mathrm{~A}$ current source. This current splits evenly and flows through both halves of the bridge. Thus, $100 \mu \mathrm{~A}$ flows through the RTD to generate an output voltage based on its resistance. A 3-wire RTD is used to balance the line resistance in both $100 \Omega$ legs of the bridge to improve accuracy.


Figure 60. Single Supply RTD Amplifier
Amplifiers A2 and A3 are configured in the two op amp IA discussed above. Their resistors are chosen to produce a gain of 274, such that each $1^{\circ} \mathrm{C}$ increase in temperature results in a 10 mV change in the output voltage, for ease of measurement. A $0.01 \mu \mathrm{~F}$ capacitor is included in parallel with the $100 \mathrm{k} \Omega$ resistor on amplifier A3 to filter out any unwanted noise from this high gain circuit. This particular RC combination creates a pole at 1.6 kHz .

## A +2.5 V Reference from a +3 V Supply

In many single-supply applications, the need for a 2.5 V reference often arises. Many commercially available monolithic 2.5 V references require at least a minimum operating supply voltage of 4 V . The problem is exacerbated when the minimum operating system supply voltage is +3 V . The circuit illustrated in Figure 61 is an example of a +2.5 V that operates from a single +3 V supply. The circuit takes advantage of the OP291's rail-to-rail input and output voltage ranges to amplify an AD589's 1.235 V output to +2.5 V . The OP291's low TCV $\mathrm{T}_{\mathrm{O}}$ of $1 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ helps to maintain an output voltage temperature coefficient of less than $200 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$. The circuit's overall temperature coefficient is dominated by R2 and R3's temperature coefficient. Lower tempco resistors are recommended. The entire circuit draws less than $420 \mu \mathrm{~A}$ from a +3 V supply at $25^{\circ} \mathrm{C}$.


Figure 61. A +2.5 $V$ Reference that Operates on a Single +3 V Supply

## +5 V Only, 12-Bit DAC Swings Rail-to-Rail

The OP291 or OP491 are ideal for use with a CMOS DAC to generate a digitally controlled voltage with a wide output range. Figure 62 shows the DAC8043 used in conjunction with the AD589 to generate a voltage output from 0 V to 1.23 V The DAC is actually operated in "voltage switching" mode where the reference is connected to the current output, $\mathrm{I}_{\mathrm{OUT}}$, and the output voltage is taken from the $\mathrm{V}_{\text {ReF }}$ pin. This topology is inherently noninverting as opposed to the classic current output mode, which is inverting and, therefore, unsuitable for single supply.


Figure 62. +5 V Only, 12-Bit DAC Swings Rail-to-Rail

The OP291 serves two functions. First, it is required to buffer the high output impedance of the DAC's $\mathrm{V}_{\text {REF }}$ pin, which is on the order of $10 \mathrm{k} \Omega$. The op amp provides a low impedance output to drive any following circuitry. Secondly, the op amp amplifies the output signal to provide a rail-to-rail output swing. In this particular case, the gain is set to 4.1 to generate a 5.0 V output when the DAC is at full scale. If other output voltage ranges are needed, such as 0 to 4.095 , the gain can easily be adjusted by altering the value of the resistors.

## A High Side Current Monitor

In the design of power supply control circuits, a great deal of design effort is focused on ensuring a pass transistor's long-term reliability over a wide range of load current conditions. As a result, monitoring and limiting device power dissipation is of prime importance in these designs. The circuit illustrated in Figure 63 is an example of a +5 V , single-supply high side current monitor that can be incorporated into the design of a voltage regulator with fold-back current limiting or a high current power supply with crowbar protection. This design uses an OP291's rail-to-rail input voltage range to sense the voltage drop across a $0.1 \Omega$ current shunt. A p-channel MOSFET used as the feedback element in the circuit converts the op amp's differential input voltage into a current. This current is then applied to R2 to generate a voltage that is a linear representation of the load current. The transfer equation for the current monitor is given by:

$$
\text { Monitor Output }=R 2 \times\left(\frac{R_{\text {SENSE }}}{R 1}\right) \times I_{L}
$$

For the element values shown, the Monitor Output's transfer characteristic is $2.5 \mathrm{~V} / \mathrm{A}$.


Figure 63. A High-Side Load Current Monitor

A +3 V, Cold Junction Compensated Thermocouple Amplifier The OP291's low supply operation makes it ideal for +3 V battery powered applications such as the thermocouple amplifier shown in Figure 64. The K-type thermocouple terminates in an isothermal block where the junctions' ambient temperature is continuously monitored using a simple 1 N 914 diode. The diode corrects the thermal EMF generated in the junctions by feeding a small voltage, scaled by the $1.5 \mathrm{M} \Omega$ and $475 \Omega$ resistors, to the op amp.
To calibrate this circuit, immerse the thermocouple measuring junction in a $0^{\circ} \mathrm{C}$ ice bath, and adjust the $500 \Omega$ pot to zero volts out. Next, immerse the thermocouple in a $250^{\circ} \mathrm{C}$ temperature bath or oven and adjust the Scale Adjust pot for an output voltage of 2.50 V . Within this temperature range, the K-type thermocouple is accurate to within $\pm 3^{\circ} \mathrm{C}$ without linearization.


Figure 64. A 3 V, Cold Junction Compensated Thermocouple Amplifier

## Single Supply, Direct Access Arrangement for Modems

An important building block in modems is the telephone line interface. In the circuit shown in Figure 65, a direct access arrangement is utilized for transmitting and receiving data from the telephone line. Amplifier A1 is the receiving amplifier, and amplifiers A2 and A3 are the transmitters. The forth amplifier, A4, generates a pseudo ground half way between the supply voltage and ground. This pseudo ground is needed for the ac coupled bipolar input signals.


Figure 65. Single Supply Direct Access Arrangement for Modems
The transmit signal, TXA, is inverted by A2 and then re-inverted by A3 to provide a differential drive to the transformer, where each amplifier supplies half the drive signal. This is needed because of the smaller swings associated with a single supply as opposed to a dual supply. Amplifier A1 provides some gain for the received signal, and it also removes the transmit signal present at the transformer from the receive signal. To do this, the drive signal from A2 is also fed to the noninverting input of A1 to cancel the transmit signal from the transformer. The OP491's bandwidth of 3 MHz and rail-to-rail output swings ensures that it can provide the largest possible drive to the transformer at the frequency of transmission.

A + $\mathbf{3} \mathrm{V}, \mathbf{5 0} \mathbf{~ H z} / 60 \mathrm{~Hz}$ Active Notch Filter with False Ground To process ac signals in a single-supply system, it is often best to use a false-ground biasing scheme. A circuit that uses this approach is illustrated in Figure 66. In this circuit, a false-ground circuit biases an active notch filter used to reject $50 \mathrm{~Hz} / 60 \mathrm{~Hz}$ power line interference in portable patient monitoring equipment. Notch filters are quite commonly used to reject power line frequency interference which oftentimes obscures low frequency physiological signals, such as heart rates, blood pressure readings, EEGs, EKGs, et cetera. This notch filter effectively squelches 60 Hz pickup at a filter $Q$ of 0.75 . Substituting $3.16 \mathrm{k} \Omega$ resistors for the $2.67 \mathrm{k} \Omega$ resistors in the twin- T section (R1 through R5) configures the active filter to reject 50 Hz interference.


Figure 66. A +3 V Single-Supply, $50 \mathrm{~Hz} / 60 \mathrm{~Hz}$ Active Notch Filter with False Ground
Amplifier A3 is the heart of the false-ground bias circuit. It simply buffers the voltage developed by R9 and R10 and is the reference for the active notch filter. Since the OP491 exhibits a rail-to-rail input common-mode range, R9 and R10 are chosen to split the +3 V supply symmetrically. An in-the-loop compensation scheme is used around the OP491 that allows the op amp to drive C 6 , a $1 \mu \mathrm{~F}$ capacitor, without oscillation. C6 maintains a low impedance ac ground over the operating frequency range of the filter.
The filter section uses a pair of OP491s in a twin-T configuration whose frequency selectivity is very sensitive to the relative matching of the capacitors and resistors in the twin-T section. Mylar is the material of choice for the capacitors, and the relative matching of the capacitors and resistors determines the filter's passband symmetry. Using $1 \%$ resistors and $5 \%$ capacitors produces satisfactory results.

## Single-Supply Half-Wave and Full-Wave Rectifiers

An OP291/OP491 configured as a voltage follower operating on a single supply can be used as a simple half-wave rectifier in low-frequency ( $<2 \mathrm{kHz}$ ) applications. A full-wave rectifier can be configured with a pair of OP291s as illustrated in Figure 67. The circuit works in the following way: When the input signal is above 0 V , the output of amplifier A1 follows the input signal. Since the noninverting input of amplifier A2 is connected to A1's output, op amp loop control forces the A2's inverting input to the same potential. The result is that both terminals of R1 are equipotential; i.e., no current flows. Since there is no current flow in R1, the same condition exists upon R2; thus, the output of the circuit tracks the input signal. When the input signal is below 0 V , the output voltage of A 1 is forced to 0 V . This condition now forces A2 to operate as an inverting voltage follower because the noninverting terminal of A 2 is at 0 V as well. The output voltage at $V_{\text {OUT }} A$ is then a full-wave rectified version of the input signal. If needed, a buffered, half-wave rectified version of the input signal is available at $V_{\text {OUT }} B$.


Figure 67. Single-Supply Half-Wave and Full-Wave Rectifiers Using an OP291

|  | 491 | ICE | acro-model | Rev. ARG/ | $\begin{aligned} & 1 / 94 \\ & \mathrm{DI} \end{aligned}$ |
| :---: | :---: | :---: | :---: | :---: | :---: |
| * |  |  |  |  |  |
| ${ }^{\star} \mathrm{Co}$ | pyrig | $1994$ | y Analog Devices |  |  |
| $\begin{aligned} & \text { * } \operatorname{Ref} \\ & \text { * this } \\ & \text { * visi } \\ & \text { * } \end{aligned}$ | fer to mod ons i | READ <br> indic he Li | ME.DOC" file for Li tes your acceptance of ense Statement. | cense Stat of the term | and |
| * No | de as | nmen |  |  |  |
|  |  |  | noninverting input inverting input |  |  |
| * |  |  | positive | supply |  |
| * |  |  | n | egative |  |
| * |  |  |  | output |  |
| * |  |  |  |  |  |
| .SUB | CKT | OP491 | 12950 | 045 |  |
| * |  |  |  |  |  |
| * INP | PUT | TAGE |  |  |  |
| * |  |  |  |  |  |
| I1 | 99 | 7 | 8.12E-6 |  |  |
| Q1 | 6 | 4 | 7 QP |  |  |
| Q2 | 5 | 3 | 7 QP |  |  |
| D1 | 3 | 99 | DX |  |  |
| D2 | 4 | 99 | DX |  |  |
| D3 | 3 | 4 | DX |  |  |
| D4 | 4 | 3 | DX |  |  |
| R1 | 3 | 8 | 5E3 |  |  |
| R2 | 4 | 2 | 5E3 |  |  |
| R3 | 5 | 50 | 6.37 E 3 |  |  |
| R4 | 6 | 50 | 6.37 E 3 |  |  |
| EOS | 8 | 1 | POLY(1) $(16,39)$ | -0.5E-3 | 316 |
| IOS | 3 | 4 | 10E-9 |  |  |
| GB1 | 3 | 98 | $(21,98) 100 \mathrm{E}-9$ |  |  |
| GB2 | 4 | 98 | $(21,98) 100 \mathrm{E}-9$ |  |  |
| CIN | 1 | 2 | 1E-12 |  |  |
|  |  |  |  |  |  |
| ${ }_{\star}^{*} 1 \mathrm{ST}$ | GAI | STA |  |  |  |
| EREF | 98 | 0 | $(39,0) \quad 1$ |  |  |
| G1 | 98 | 9 | $(6,5) \quad 31.416 \mathrm{E}$ |  |  |
| R7 | 9 | 98 | 1E6 |  |  |
| EC1 | 99 | 10 | POLY(1) $(99,39)$ | -0.52 | 1 |
| EC2 | 11 | 50 | POLY(1) $(39,50)$ | -0.52 | 1 |
| D5 | 9 | 10 | DX |  |  |
| D6 | 11 | 9 | DX |  |  |
| * |  |  |  |  |  |
| $\text { * } 2 \mathrm{Nl}$ | D GA | STA | GE AND DOMINAN | NT POLE |  |
| G2 | 98 | 12 | $(9,39) \quad 8.12 \mathrm{E}-6$ |  |  |
| R8 | 12 | 98 | 7.840E9 |  |  |
| C2 | 12 | 98 | 16.24E-12 |  |  |
| D7 | 12 | 13 | DX |  |  |
| D8 | 14 | 12 | DX |  |  |
| V1 | 99 | 13 | 0.58 |  |  |
| V2 | 14 | 50 | 0.58 |  |  |
| * |  |  |  |  |  |
| * CO | MMO | -MO | DE STAGE |  |  |
| * |  |  |  |  |  |
| ECM |  | 98 | POLY(2) $(1,39)(2$, | ,39) 00.5 |  |
| R9 | 15 | 16 | 1 E 6 |  |  |
| R10 | 16 | 98 | 10 |  |  |

```
*
* POLE AT 2.5 MHz
*
G3 98 18 (12,39) 1E-6
R11 18 98 1E6
C4 18 98 63.662E-15
*
* BIAS CURRENT-VS-COMMON-MODE VOLTAGE
EP 97 0 (99,0) 1
VB }99017\quad1.
RB 17 50 1E9
E3 19 0 (15,17) 16
D13 19 20 DX
R12 20 0 1E6
G4 98 21 (20,0) 1E-3
R13 21 98 5E3
D14 21 22 DY
E4 97 22 (POLY(1)(99,98)-0.765 1
*
* POLE AT 100 MHz
*
G6 98 40 (18,39) 1E-6
R20 40 98 1E6
C10}40\quad98\quad1.592\textrm{E}-1
* OUTPUT STAGE
*
RS1 99 39 109.375E3
RS2 39 50 109.375E3
RO1 99 45 41.667
RO2 45 50 41.667
G7 45 99 (99,40) 24E-3
G8 50 45 (40,50) 24E-3
G9 98 60 (45,40)24E-3
D9 60 61 DX
D10 62 60 DX
V7 61 98 DC 0
V8 98 62 DC 0
FSY 99 50 POLY(2) V7 V8 0.247E-3 1 1
D11 41 45 DZ
D12 45 42 DZ
V5 40 41 0.131
V6 42 40 0.131
.MODEL DX D()
.MODEL DY D(IS=1E-9)
.MODEL DZ D(IS=1E-6)
.MODEL QP PNP(BF=66.667)
.ENDS
```

FEATURES
Single Supply Operation: 4.5 V to 33 V Input Common Mode Includes Ground Output Swings to Ground
High Slew Rate: 3 V/us
High Gain Bandwidth: $\mathbf{4} \mathbf{~ M H z}$
Low Input Offset Voltage
High Open-Loop Gain
No Phase Inversion
Low Cost

## APPLICATIONS

Disk Drives
Mobile Phones
Servo Controls
Modems and Fax Machines Pagers
Power Supply Monitors and Controls
Battery Operated Instrumentation

## GENERAL DESCRIPTION

The OP292/OP492 are low cost general purpose dual and quad operational amplifiers designed for single supply applications and are ideal for +5 volt systems.
Fabricated on Analog Devices' CBCMOS process, the OP292/ OP492 series has a PNP input stage that allows the input voltage range to include ground. A BiCMOS output stage enables the output to swing to ground while sinking current.
The OP292/OP492 series is unity-gain stable and features an outstanding combination of speed and performance for single or dual supply operation. The OP292/OP492 provide high slew rate, high bandwidth, with open-loop gain exceeding 40,000 and offset voltage under $800 \mu \mathrm{~V}$ (OP292) and 1 mV (OP492). With these combinations of features and low supply current, the OP292/OP492 series is an excellent choice for battery operated applications.
The OP292/OP492 series performance is specified for single or dual supply voltage operation over the extended industrial temperature range $\left(-40^{\circ} \mathrm{C}\right.$ to $\left.+125^{\circ} \mathrm{C}\right)$.
Package options for the OP292 and OP492 include plastic DIP, SO-8 (OP292) and SO-14.

PIN CONNECTIONS


14-Lead Narrow-Body SO (S Suffix)


8-Lead Epoxy DIP (P Suffix)


14-Lead Epoxy DIP (P Suffix)

$\left(@ V_{S}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V}, \mathrm{~V}_{0}=+2 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right.$ unless otherwise noted)


[^197]
## ELECTRICAL CHARACTERISTICS (@ $v_{S}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT CHARACTERISTICS |  |  |  |  |  |  |
| Offset Voltage | $\mathrm{V}_{\text {Os }}$ |  |  |  |  |  |
| OP292 |  |  |  | 1.0 | 2.0 | mV |
|  |  | $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ |  | 1.2 | 2.5 | mV |
| OP492 |  | $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ |  | 1.5 | 3 | mV |
|  |  |  |  | 1.4 | 2.5 | mV |
|  |  | $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ |  | 1.7 | 2.8 | mV |
|  |  | $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ |  | 2 | 3 | mV |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ |  |  | 375 | 700 | nA |
|  |  | $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ |  | 0.5 | 1 | $\mu \mathrm{A}$ |
| Input Offset Current | $\mathrm{I}_{\mathrm{OS}}$ |  |  | 7 | 50 | nA |
|  |  | $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ |  | 20 | 100 | nA |
|  |  | $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ |  | 0.4 | 1.2 | $\mu \mathrm{A}$ |
| Input Voltage Range |  | Note 1 | $-11$ |  | 11 |  |
| Common-Mode Rejection Ratio | CMRR | $\mathrm{V}_{\mathrm{CM}}= \pm 11 \mathrm{~V}$ | 78 | 100 |  | dB |
|  |  | $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ | 75 | 95 |  | dB |
| Large Signal Voltage Gain | $\mathrm{A}_{\text {vo }}$ | $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega, \mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V}$ | 25 | 120 |  | V/mV |
|  |  | $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ | 10 | 75 |  | $\mathrm{V} / \mathrm{mV}$ |
|  |  | $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ | 5. | 60 |  | $\mathrm{V} / \mathrm{mV}$ |
| Offset Voltage Drift | $\Delta \mathrm{V}_{\text {OS }} / \Delta \mathrm{T}$ | $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ |  | 4 | 10 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Bias Current Drift | $\Delta \mathrm{I}_{\mathrm{B}} / \Delta \mathrm{T}$ | $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ |  | 3 |  | $\mathrm{pA} /{ }^{\circ} \mathrm{C}$ |
| OUTPUT CHARACTERISTICS <br> Output Voltage Swing | $\mathrm{V}_{\mathrm{O}}$ |  |  |  |  |  |
|  |  | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ to GND | $\pm 11$ | $\pm 12.2$ |  | V |
|  |  | $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ | $\pm 10$ | $\pm 11$ |  | V |
|  |  | $\mathrm{R}_{\mathrm{L}}=100 \mathrm{k} \Omega$ to GND | $\pm 13.8$ | $\pm 14.3$ |  | V |
|  |  | $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ | $\pm 13.5$ | $\pm 14.0$ |  | mV |
|  | $\mathrm{I}_{\text {SC }}$ | Short Circuit to GND | 8 | 10.5 |  | mA |
| POWER SUPPLY |  |  |  |  |  |  |
| Power Supply Rejection Ratio | PSRR | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}= \pm 2.25 \mathrm{~V} \text { to } \pm 15 \mathrm{~V} \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C} \end{aligned}$ | $\begin{aligned} & 75 \\ & 70 \end{aligned}$ | 86 |  | dB |
|  |  |  |  | 83 |  | dB |
| Supply Current Per Amp OP292, OP492 | $\mathrm{I}_{\mathrm{SY}}$ | $\mathrm{V}_{\mathrm{O}}=0 \mathrm{~V}$ |  | 1 | 1.4 | mA |
| DYNAMIC PERFORMANCE <br> Slew Rate |  |  |  |  |  |  |
|  | SR | $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ | 2.5 | 4 |  |  |
|  |  | $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ | 2 | 3 |  | V/ $/ \mathrm{s}$ |
| Gain Bandwidth Product | GBP |  |  | 4 |  | MHz |
| Phase Margin | $\phi_{\text {m }}$ | $\mathrm{f}_{\mathrm{O}}=1 \mathrm{kHz}$ |  | 75 |  | Degrees |
| Channel Separation | CS |  |  | 100 |  | dB |
| NOISE PERFORMANCE |  |  |  |  |  |  |
| Voltage Noise | $\mathrm{e}_{\mathrm{n}} \mathrm{p}$-p | 0.1 Hz to 10 Hz |  | 25 |  | $\mu \mathrm{V}$ p-p |
| Voltage Noise Density | $\mathrm{e}_{\mathrm{n}}$ | $\mathrm{f}=1 \mathrm{kHz}$ |  | 15 |  | $\mathrm{nV} / \sqrt{ } \underline{\mathrm{Hz}}$ |
| Current Noise Density | $i_{n}$ |  |  | 0.7 |  | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |

[^198]WAFER TEST LIMITS
$\left(@ V_{S}=+5.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{CM}}=2.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right.$ unless otherwise noted)

| Parameter | Symbol | Conditions | Limit | Units |
| :---: | :---: | :---: | :---: | :---: |
| Offset Voltage | $\mathrm{V}_{\text {OS }}$ |  | $\pm 600$ | $\mu \mathrm{V}$ max |
| Input Bias Current | $\mathrm{I}_{\text {B }}$ |  | 700 | $n A \max$ |
| Input Offset Current | $\mathrm{I}_{\text {OS }}$ |  | 50 | $n A$ max |
| Input Voltage Range ${ }^{1}$ | $\mathrm{V}_{\mathrm{CM}}$ |  | 0/4 | V min/V max |
| Common-Mode Rejection | CMRR | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ to 4.0 V | 75 | dB min |
| Power Supply Rejection Ratio | PSRR | $\mathrm{V}= \pm 4.5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$ | 75 | dB min |
| Large Signal Voltage Gain | $\mathrm{A}_{\text {vo }}$ | $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega, \mathrm{V}_{\mathrm{O}}=0.1 \mathrm{~V}$ to 4 V | 25 | $\mathrm{V} / \mathrm{mV}$ min |
| Output Voltage | $\mathrm{V}_{\mathrm{O}}$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | 3.8 | $V$ min |
| Supply Current per Amp OP292, OP492 | $\mathrm{I}_{\text {SY }}$ | $\mathrm{V}_{\mathrm{O}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=$ Open | 1.2 | mA max |

NOTES
Electrical tests and wafer probe to the limits shown. Due to variations in assembly methods and normal yield loss, yield after packaging is not guaranteed for standard product dice. Consult factory to negotiate specifications based on dice lot qualifications through sample lot assembly and testing.
${ }^{1}$ Guaranteed by CMR test.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

| Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . . +33 V |  |
| :---: | :---: |
| Input Voltage ${ }^{2}$ | -15 V to +14 V |
| Differential Input Voltage ${ }^{2}$. . . . . . . . . . . . . . . . . . . . . . V |  |
| Output Short-Circuit Duration |  |
| Storage Temperature Range |  |
| P, S Package | $65^{\circ} \mathrm{C}$ to |
| Operating Temperature Range |  |
| OP292/OP492 P, S | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Junction Temperature Range |  |
| P, S Package | $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Lead Temperature Range (Sol | . . . . $+300^{\circ} \mathrm{C}$ |


| Package Type | $\boldsymbol{\theta}_{\mathbf{J A}}{ }^{\mathbf{3}}$ | $\boldsymbol{\theta}_{\mathbf{J C}}$ | Units |
| :--- | :--- | :--- | :--- |
| 8-Pin Plastic DIP (P) | 103 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 14-Pin Plastic DIP (P) | 83 | 39 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin SO (S) | 158 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 14-Pin SO (S) | 120 | 36 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTES

${ }^{1}$ Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
${ }^{2}$ For supply voltages less than +36 V , the absolute maximum input voltage is equal to the supply voltage.
${ }^{3} \theta_{\mathrm{IA}}$ is specified for the worst case conditions, i.e., $\theta_{\mathrm{JA}}$ is specified for device in socket for P-DIP package; $\theta_{\mathrm{JA}}$ is specified for device soldered in circuit board for SOIC package.

## ORDERING GUIDE

| Model | Temperature Range | Package Option ${ }^{\star}$ |
| :--- | :--- | :--- |
| OP292GP | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| OP292GS | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | SO-8 |
| OP492GP | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{N}-14$ |
| OP492GS | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | SO-14 |
| OP292/492GBC | $+25^{\circ} \mathrm{C}$ | DICE |

[^199]
## DICE CHARACTERISTICS



OP292 Die Size $0.040 \times 0.057$ Inch, 2,280 Sq. Mils Substrate Connected to $V+$, Number of Transistors: Bipolar 47, MOSFET 5.


OP492 Die Size $0.057 \times 0.068$ Inch, 3,876 Sq. Mils Substrate Connected to $V+$, Number of Transistors: Bipolar 91, MOSFET 9.


Figure 1. OP292 Input Offset Voltage Distribution @ +5 V


Figure 2. OP292 Input Offset Voltage Distribution @ $\pm 15$ V


Figure 3. OP292 Temperature Drift (TCV Os ) Distribution @ +5 V


Figure 4. OP492 Input Offset Voltage Distribution @ +5 V


Figure 5. OP492 Input Offset Voltage Distribution $@ \pm 15$ V


Figure 6. OP492 Temperature Drift ( $T_{C V}$ os $)$ Distribution @ +5 V


Figure 7. OP292 Temperature Drift (TCV os ) Distribution @ $\pm 15 \mathrm{~V}$


Figure 8. OP292 Open-Loop Gain vs. Temperature @+5V


Figure 9. OP292 Open-Loop Gain vs. Temperature $@ \pm 15$ V


Figure 10. OP492 Temperature Drift ( $T C V_{\text {OS }}$ ) Distribution $@ \pm 15$ V


Figure 11. OP492 Open-Loop Gain vs. Temperature @ +5V


Figure 12. OP492 Open-Loop Gain vs. Temperature @ $\pm 15$ V


Figure 13. OP292 Supply Current per Amplifier vs. Temperature


Figure 14. OP292 Slew-Rate vs. Temperature


Figure 15. OP292/OP492 Open-Loop Gain and Phase vs. Frequency @ +5 V


Figure 16. OP492 Supply Current per Amplifier vs. Temperature


Figure 17. OP492 Slew-Rate vs. Temperature


Figure 18. OP292/OP492 Open-Loop Gain/Phase vs. Frequency @ $\pm 15$ V


Figure 19. OP292/OP492 Closed-Loop Gain/Phase vs. Frequency@+5 V


Figure 20. OP292/OP492 CMR vs. Frequency @ +5V


Figure 21. OP292/OP492 PSR vs. Frequency @ +5 V


Figure 22. OP292/OP492 Closed-Loop Gain/Phase vs. Frequency@ $\pm 15 \mathrm{~V}$


Figure 23. OP292/OP492 CMR vs. Frequency @ $\pm 15$ V


Figure 24. OP292/OP492 PSR vs. Frequency @ $\pm 15$ V


Figure 25. OP292/OP492 V ${ }_{\text {Out }}$ Swing vs. Temperature @ +5V


Figure 26. OP292/OP492 Input Bias Current vs. Temperature @ +5V


Figure 27. OP292/OP492 Channel Separation


Figure 28. OP292/OP492 V Out Swing vs. Temperature @ $\pm 15$ V


Figure 29. OP292/OP492 Input Bias Current vs. Temperature@ $\pm 15$ V


Figure 30. OP292/OP492 $I_{B}$ Current vs. Common Mode Voltage


Figure 31. Voltage Noise Density

## APPLICATION INFORMATION

## PHASE REVERSAL

The OP492 has built-in protection against phase reversal when the input voltage goes to either supply rail. In fact it is safe for the input to exceed either supply rail by up to 0.6 V with no risk of phase reversal. However, the input should not go beyond the positive supply rail by more than 0.9 V , otherwise the output will reverse phase. If this condition can occur, the problem can be fixed by adding a $5 \mathrm{k} \Omega$ current limiting resistor in series with the input pin. With this addition, the input can go to more than 5 V beyond the positive rail without phase reversal.
An input voltage that is as much as 5 V below the negative rail will not result in phase reversal.


Figure 32. Output Can Reverse Phase If Input Exceeds the Positive Supply $(V+$ ) by More Than 0.9 V


Figure 33. No Negative Rail Phase Reversal, Even with Input Signal at 5 V Below Ground

## Power Supply Considerations

The OP292/OP492 are designed to operate equally well at single +5 V or $\pm 15 \mathrm{~V}$ supplies. The lowest supply voltage recommended is 4.5 V .

It is a good design practice to bypass the supply pins with a $0.1 \mu \mathrm{~F}$ ceramic capacitor. It helps improve filtering of high frequency noise.
For dual supply operation, the negative supply ( $\mathrm{V}-$ ) must be applied at the same time, or before $\mathrm{V}+$. If $\mathrm{V}+$ is applied before $\mathrm{V}-$, or in the case of a loss of V - supply, while either input is connected to ground or other low impedance source, excessive input current may result. Potentially damaging levels of input current can destroy the amplifier. If this condition can exist, simply add a 1 k or larger resistor in series with the input to eliminate the problem.

## TYPICAL APPLICATIONS

Direct Access Arrangement for Telephone Line Interface Figure 34 shows a +5 V-only transmit/receive telephone line interface for a modem circuit. It allows full duplex transmission of modem signals on a transformer-coupled $600 \Omega$ line in a differential manner. The transmit section gain can be set for the specific modem device output. Similarly the receive amplifier gain can be appropriately selected based on the modem device input requirements. The circuit operates on a single +5 V supply. The standard value resistors allow the use of a SIP packaged resistor array; this, coupled with a quad op amp in a single package, offers a compact, low part-count solution.

Figure 34. A Universal Direct Access Arrangement for Telephone Line Interface


## A Single Supply Instrumentation Amplifier

A low cost single supply instrumentation amplifier can be built as shown in Figure 35. The circuit utilizes two op amps to form a high input impedance differential amplifier. Gain can be set by selecting resistor $\mathrm{R}_{\mathrm{G}}$ which can be calculated using the transfer function equation. Normally, $\mathrm{V}_{\text {Reference }}$ is set to 0 V . Then the output voltage is a function of the gain times the differential input voltage. However, the output can be offset by setting $\mathrm{V}_{\text {REFERENCE }}$ from 0 V to 4 V , as long as the input commonmode voltage of the amplifier is not exceeded.


Figure 35. A Single Supply Instrumentation Amplifier
In this configuration, while the output can swing to near zero volts, one needs to be careful because the input's common-mode voltage range cannot operate to zero volts. This is because of the limitation of the circuit configuration where the first amplifier must be able to swing below ground in order to attain a 0 V common-mode voltage, which it cannot do. Depending on the gain of the instrumentation amplifier, the input common-mode extends to within about 0.3 V of zero. One can easily calculate the worst-case common-mode limit for a given gain.

## DAC Output Amplifier

The OP292/OP492 are ideal for buffering the output of single supply D/A converters. Figure 36 shows a typical amplifier used to buffer the output of a CMOS DAC that is connected for single supply operation. To do that, the normally current output 12-bit CMOS DAC ( $\mathrm{R}-2 \mathrm{R}$ ladder type) is connected backward to produce a voltage output. This operating configuration necessitates a low voltage reference. In this case, a 1.235 V low power reference is used. The relatively high output impedance (10k) is buffered by the OP292 and at the same time gained up to a much more usable level. The potentiometer provides an accurate gain trim for a 4.095 V full-scale, allowing 1 mV increment per LSB of control resolution.
The DAC8043 device comes in an 8-pin DIP package providing a cost-effective, compact solution to a 12 -bit analog channel.


Figure 36. A 12-Bit Single-Supply DAC With Serial Bus Control

## A $50 \mathrm{~Hz} / 60 \mathrm{~Hz}$ Single-Supply Notch Filter

Figure 37 shows a notch filter that achieves nearly 30 dB of 60 Hz rejection while powered by only a single 12 V supply. The circuit also works well on +5 V systems. The filter utilizes a twin-T configuration whose frequency selectivity depends heavily on the relative matching of the capacitors and resistors in the twin-T section. Mylar is a good choice for the twin-T's capacitors, and the relative matching of the capacitors and resistors determines the filter's passband symmetry. Using $1 \%$ resistors and $5 \%$ capacitors produces satisfactory results.
The amount of rejection and the Q of the filter is solely determined by one resistor, and is shown in the table. The bottom amplifier is used to split the supply to bias the amplifier to midlevel. The circuit can be modified to reject 50 Hz by simply changing the resistors in the twin-T section (R1 through R4) from 2.67 k to 3.16 k , and change R 5 to $1 / 2$ of 3.16 k . For best results, the common value resistors can be from a resistor array for optimum matching characteristics.


Figure 37. A Single-Supply $50 \mathrm{~Hz} / 60 \mathrm{~Hz}$ Notch Filter


Figure 38. A 4-Pole Bessel Low Pass Filter Using SallenKey Topology

## A 4-Pole Bessel Low-Pass Filter

The linear phase filter in Figure 38 is designed to roll off at a voiceband cutoff frequency of 3.6 kHz . The 4 poles are formed by two cascading stages of two-pole Sallen-Key filters.

## A Low Cost, Linearized Thermistor Amplifier

An inexpensive thermometer amplifier circuit can be implemented using low cost thermistors. One such implementation is shown in Figure 39. The circuit measures temperature over the range of $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ to an accuracy of $\pm 0.3^{\circ} \mathrm{C}$ as the linearization circuit works well within a narrow temperature range. However, it can measure higher temperature but at a slightly reduced accuracy. To achieve the aforementioned accuracy, the thermistor's nonlinearity must be corrected. This is done by connecting the thermistor in parallel with the 10 k in the feedback loop of the first stage amplifier. A constant operating current of $281 \mu \mathrm{~A}$ is supplied by the resistor R1 with the +5 V reference from the REF-195 such that the thermistor's selfheating error is kept below $0.1^{\circ} \mathrm{C}$.
In many cases, the thermistor is placed some distance from the signal conditioning circuit. Under this condition, a $0.1 \mu \mathrm{~F}$ capacitor placed across R 2 will help to suppress noise pickup.
This linearization network creates an offset voltage which is corrected by summing a compensating current with potentiometer P1. The temperature dependent signal is amplified by the second stage, producing a transfer coefficient of $-10 \mathrm{mV} /{ }^{\circ} \mathrm{C}$ at the output.
To calibrate, a precision decade box can be used in place of the thermistor. For $0^{\circ} \mathrm{C}$ trim, the decade box is set to 32.650 k , and Pl is adjusted until the circuit's output reads 0 V . To trim the circuit at the full-scale temperature of $70^{\circ} \mathrm{C}$, the decade box is then set to 1.752 k and P 2 is adjusted until the circuit reads -0.70 V .


Figure 39. A Low Cost Linearized Thermistor Amplifier

## A Single-Supply Ultrasonic Clamping/Limiting Receiver Amplifier

Figure 40 shows an ultrasonic receiver amplifier using the nonlinear impedance of low cost diodes to effectively control the gain for wide dynamic range. This circuit amplifies a 40 kHz ultrasonic signal through a pair of low cost clamping amplifiers before feeding a bandpass filter to extract a clean 40 kHz signal for processing.
The signal is ac-coupled into the false-ground bias node by virtue of the capacitive piezoelectric sensing element. Rather than using an amplifier to generate a supply splitting bias, the false ground voltage is generated by a low cost resistive voltage divider.
Each amplifier stage provides ac gain while passing on the dc self-bias. As long as the output signal at each stage is less than a diode's forward voltage, each amplifier has unrestricted gain to amplify low level signals. However, as the signal strength increases, the feedback diodes begin to conduct, shunting the feedback current, and thus reducing the gain. Although distorting the waveform, the diodes effectively maintain a relatively constant amplitude even with large signals that otherwise would saturate the amplifier. In addition, this design is considerably more stable than the feedback type AGC.
The overall circuit has a gain range from -2 to -400 , where the inversion comes from the bandpass filter stage. Operating with a Q of 5, the filter restores a clean, undistorted signal to the output. The circuit also work well with 5 V supply systems.


Figure 40. A 40 kHz Ultrasonic Clamping/Limiting Receiver Amplifier

## Precision Single-Supply Voltage Comparator

The OP292/OP492 have excellent overload recovery characteristics, making them suitable for precision comparator applications. Figure 41 shows the saturation recovery characteristics of the OP492. The amplifier exhibits very little propagation delay. The amplifier compares a signal precisely to less than 0.5 mV offset error.


Figure 41. The OP492 Has Fast Overload Recovery for Comparator Applications

## Programmable Precision Window Comparator

The OP292/OP492 can be used for precise level detection such as in test equipment where a signal is measured within a range. Figure 42 shows such an implementation. The threshold voltage level is set by a pair of 12 -bit D/A converters. The DACs have serial interface thus minimizing interconnection requirements. The DAC8512 has a control resolution of $1 \mathrm{mV} / \mathrm{bit}$. Thus for 5 V supply operation, maximum DAC output is 4.095 V . However, the OP292 will accept a maximum input of 4.0 V .


Figure 42. Programmable Window Comparator with 12-Bit Threshold Level Control

```
* OP292 SPICE Macro-model Rev. A, 6/93
*
*
* Copyright 1993 by Analog Devices
* Refer to "README.DOC" file for License Statement. Use of
* this model indicates your acceptance of the terms and pro-
* visions in the License Statement.
*
* Node assignments
* noninverting input
*
*
*
*
*
.SUBCKT OP292
|
*
* INPUT STAGE AND POLE AT 40 MHz
*
I1 
IOS 2 1 10E-9
EOS 2 3 POLY(1) (21,30) 1.5E-3 75
CIN 1 2 3E-12
lll
R3 5 50 2E3
R4 6 50 2E3
R5 4 7 966
R6 4 8 966
C1 5 6 .995E-12
*
* GAIN STAGE
EREF 98 0 (30,0) 1
G1 98 9 (5,6)500E-6
R7 9 98 210.819E3
D1 9 10 DX
D2 11 9 DX
V1 
V2 11 50 . }
*
* ZERO/POLE AT 6 MHz/12 MHz
*
E1 12 98 (9,30) 2
R8 12 13 1
R9 13 98 1
C3 12 13 26.526E-9
*
* ZERO AT 15 MHz
*
E2 14 98 (13,30) 1E6
R10 14 15 1E6
R11 15 98 1
C4 14 15 10.610E-15
*
* COMMON MODE STAGE WITH ZERO AT }40\textrm{kHz
*
ECM 20 98 POLY(2) (1,30) (2,30) 0}00.
R20 20 21 1E6
R21 21 98 1
C5 20
```


## OP292/0P492

* 
* POLE AT 100 MHz
* 

| G2 | 98 | 16 | $(15,30) 1$ |
| :--- | :--- | :--- | :--- |
| R12 | 16 | 98 | 1 |
| C6 | 16 | 98 | $1.592 \mathrm{E}-9$ |

* 
* OUTPUT STAGE
* 

RS1 $99 \quad 30 \quad$ 1E6
RS2 $30 \quad 50 \quad$ 1E6
ISY $99 \quad 50 \quad .44 \mathrm{E}-3$

G3 $31 \quad 50 \quad \operatorname{POLY}(1)(16,30)-1.635 \mathrm{E}-64 \mathrm{E}-6$
R16 $31 \quad 50$ 1E6
DCL $50 \quad 31$ DZ

| I2 | 99 | 32 | $250 \mathrm{E}-6$ |
| :--- | :--- | :--- | :--- |

$\begin{array}{llll}\text { RCL } & 33 & 50 & 56\end{array}$
M1 $32 \quad 31 \quad 50 \quad 50 \quad \mathrm{MN} \mathrm{L}=9 \mathrm{E}-6 \mathrm{~W}=1000 \mathrm{E}-6 \mathrm{AD}=15 \mathrm{E}-9 \mathrm{AS}=15 \mathrm{E}-9$
M2 $34 \quad 31 \quad 50 \quad 50 \quad$ MN L=9E-6 W $=1000 \mathrm{E}-6 \mathrm{AD}=15 \mathrm{E}-9 \mathrm{AS}=15 \mathrm{E}-9$

| CC | 31 | 32 | $14 \mathrm{E}-12$ |
| :--- | :--- | :--- | :--- |

Q3 $\quad 99$

Q4 $\quad$| 33 | 32 | 34 | QPA |
| :--- | :--- | :--- | :--- | :--- |

Q5 $\quad 31 \quad 33 \quad 50 \quad$ QNA
.MODEL QNA NPN(IS $=1.19 \mathrm{E}-16 \mathrm{BF}=253 \mathrm{NF}=0.99 \mathrm{VAF}=193 \mathrm{IKF}=2.76 \mathrm{E}-3$
$+\mathrm{ISE}=2.57 \mathrm{E}-13 \mathrm{NE}=5 \mathrm{BR}=0.4 \mathrm{NR}=0.988 \mathrm{VAR}=15 \mathrm{IKR}=1.465 \mathrm{E}-4$
$+\mathrm{ISC}=6.9 \mathrm{E}-16 \mathrm{NC}=0.99 \mathrm{RB}=2.0 \mathrm{E} 3 \quad \mathrm{IRB}=7.73 \mathrm{E}-6 \mathrm{RBM}=132.8 \mathrm{RE}=4 \mathrm{RC}=209$
$+\mathrm{CJE}=2.1 \mathrm{E}-13 \mathrm{VJE}=0.573 \mathrm{MJE}=0.364 \mathrm{FC}=0.5 \mathrm{CJC}=1.64 \mathrm{E}-13 \mathrm{VJC}=0.534 \mathrm{MJC}=0.5$
$+\mathrm{CJS}=1.37 \mathrm{E}-12 \mathrm{VJS}=0.59 \mathrm{MJS}=0.5 \mathrm{TF}=0.43 \mathrm{E}-9 \mathrm{PTF}=30$ )
. MODEL QPA PNP(IS $=5.21 \mathrm{E}-17 \mathrm{BF}=131 \mathrm{NF}=0.99 \mathrm{VAF}=62 \mathrm{IKF}=8.35 \mathrm{E}-4$
$+\mathrm{ISE}=1.09 \mathrm{E}-14 \mathrm{NE}=2.61 \mathrm{BR}=0.5 \mathrm{NR}=0.984 \mathrm{VAR}=15 \mathrm{IKR}=3.96 \mathrm{E}-5$
$+\mathrm{ISC}=7.58 \mathrm{E}-16 \mathrm{NC}=0.985 \mathrm{RB}=1.52 \mathrm{E} 3 \mathrm{IRB}=1.67 \mathrm{E}-5 \mathrm{RBM}=368.5 \mathrm{RE}=6.31 \mathrm{RC}=354.4$
$+\mathrm{CJE}=1.1 \mathrm{E}-13 \mathrm{VJE}=0.745 \mathrm{MJE}=0.33 \mathrm{FC}=0.5 \mathrm{CJC}=2.37 \mathrm{E}-13 \mathrm{VJC}=0.762 \mathrm{MJC}=0.4$
$+\mathrm{CJS}=7.11 \mathrm{E}-13 \mathrm{VJS}=0.45 \mathrm{MJS}=0.412 \mathrm{TF}=1.0 \mathrm{E}-9 \mathrm{PTF}=30$ )
.MODEL MN NMOS(LEVEL $=3$ VTO $=1.3 \mathrm{RS}=0.3 \mathrm{RD}=0.3$
$+\mathrm{TOX}=8.5 \mathrm{E}-8 \mathrm{LD}=1.48 \mathrm{E}-6 \mathrm{WD}=1 \mathrm{E}-6 \mathrm{NSUB}=1.53 \mathrm{E} 16 \mathrm{UO}=650 \mathrm{DELTA}=10 \mathrm{VMAX}=2 \mathrm{E} 5$
$+\mathrm{XJ}=1.75 \mathrm{E}-6 \mathrm{KAPPA}=0.8 \mathrm{ETA}=0.066 \mathrm{THETA}=0.01 \mathrm{TPG}=1 \mathrm{CJ}=2.9 \mathrm{E}-4 \mathrm{~PB}=0.837$
$+\mathrm{MJ}=0.407 \mathrm{CJSW}=0.5 \mathrm{E}-9 \mathrm{MJSW}=0.33)$
.MODEL QP PNP(BF=61.5)
.MODEL DX D
.MODEL DZ D(BV=3.6)
.ENDS OP292

```
* OP492 SPICE Macro-model
Rev. A, 6/93
ARG / PMI
*
* Copyright }1993\mathrm{ by Analog Devices
*
* Refer to "README.DOC" file for License Statement. Use of
\star this model indicates your acceptance of the terms and pro-
* visions in the License Statement.
\star
* Node assignments
```



```
\star
* INPUT STAGE AND POLE AT 40 MHz
I1 }\quad99\quad4\quad50\textrm{E}-
IOS 2 1 10E-9
EOS 2 3 POLY(1) (21,30) 1.5E-3 75
CIN 1 2 3E-12
Q1 
Q2 
R3 5 50 2E3
R4 6 50 2E3
R5 4 7 7 966
R6 4 8 966
C1 5 6 .995E-12
*
* GAIN STAGE
*
EREF 98 0 (30,0) 1
G1 98 9 (5,6) 500E-6
R7 9 98 210.819E3
D1 }9\quad10\quadD
D2 11 9 0
V1 }99\quad10 .6 
V2 11 50 .6
*
* ZERO/POLE AT 6 MHz/12 MHz
\star
E1 12 98 (9,30) 2
R8 12 13 1
R9 13 98 1
C3 12 13 26.526E-9
*
* ZERO AT 15 MHz
\star
E2 14 98 (13,30) 1E6
R10 14 15 1E6
R11 15 98 1
C4 }14\quad14\quad15\quad10.610\textrm{E}-1
*
* COMMON MODE STAGE WITH ZERO AT 40 kHz
*
\begin{tabular}{lllllllll} 
ECM & 20 & 98 & \(\operatorname{POLY}(2)\) & \((1,30)\) & \((2,30)\) & 0 & 0.5 & 0.5
\end{tabular}
R20 \(20 \quad 21 \quad\) 1E6
R21 21 98 1
C5 20 21 3.979E-12
```

* 
* POLE AT 100 MHz
* 

| G2 | 98 | 16 | $(15,30)$ | 1 |
| :--- | :--- | :--- | :--- | :--- |
| R12 | 16 | 98 | 1, |  |
| C6 | 16 | 98 | $1.592 \mathrm{E}-9$ |  |

* 
* OUTPUT STAGE
* 

| RS1 | 99 | 30 | 1 E 6 |
| :--- | :--- | :--- | :--- |
| RS2 | 30 | 50 | 1 E 6 |
| ISY | 99 | 50 | $.44 \mathrm{E}-3$ |
| G3 | 31 | 50 | POLY(1) |
| R16 | 31 | 50 | 1 E 6 |
| DCL | 50 | 31 | DZ |
| I2 | 99 | 32 | $250 \mathrm{E}-6$ |
| RCL | 33 | 50 | 56 |
| M1 | 32 | 31 | 50 |
| M2 | 34 | 31 | 50 |
| CC | 31 | 32 | $14 \mathrm{E}-12$ |
| C3 | 99 | 32 | 34 QNA |
| Q3 | 33 | 32 | 34 QPA |
| Q4 | 31 | 33 | 50 QNA |

.MODEL QNA NPN (IS $=1.19 \mathrm{E}-16 \mathrm{BF}=253 \mathrm{NF}=0.99 \mathrm{VAF}=193 \mathrm{IKF}=2.76 \mathrm{E}-3$
$+\mathrm{ISE}=2.57 \mathrm{E}-13 \mathrm{NE}=5 \mathrm{BR}=0.4 \mathrm{NR}=0.988 \mathrm{VAR}=15 \mathrm{IKR}=1.465 \mathrm{E}-4$

+ ISC=6.9E-16 NC=0.99 RB=2.0E3 IRB=7.73E-6 RBM=132.8 RE=4 RC=209
$+\mathrm{CJE}=2.1 \mathrm{E}-13 \mathrm{VJE}=0.573 \mathrm{MJE}=0.364 \mathrm{FC}=0.5 \mathrm{CJC}=1.64 \mathrm{E}-13 \mathrm{VJC}=0.534 \mathrm{MJC}=0.5$
$+\mathrm{CJS}=1.37 \mathrm{E}-12 \mathrm{VJS}=0.59 \mathrm{MJS}=0.5 \mathrm{TF}=0.43 \mathrm{E}-9 \mathrm{PTF}=30$ )
.MODEL QPA PNP(IS $=5.21 \mathrm{E}-17 \mathrm{BF}=131 \mathrm{NF}=0.99 \mathrm{VAF}=62 \mathrm{IKF}=8.35 \mathrm{E}-4$
$+\mathrm{ISE}=1.09 \mathrm{E}-14 \mathrm{NE}=2.61 \mathrm{BR}=0.5 \mathrm{NR}=0.984 \mathrm{VAR}=15 \mathrm{IKR}=3.96 \mathrm{E}-5$
$+\mathrm{ISC}=7.58 \mathrm{E}-16 \mathrm{NC}=0.985 \mathrm{RB}=1.52 \mathrm{E} 3$ IRB $=1.67 \mathrm{E}-5 \mathrm{RBM}=368.5 \mathrm{RE}=6.31 \mathrm{RC}=354.4$
$+\mathrm{CJE}=1.1 \mathrm{E}-13 \mathrm{VJE}=0.745 \mathrm{MJE}=0.33 \mathrm{FC}=0.5 \mathrm{CJC}=2.37 \mathrm{E}-13 \mathrm{VJC}=0.762 \mathrm{MJC}=0.4$
$+\mathrm{CJS}=7.11 \mathrm{E}-13 \mathrm{VJS}=0.45 \mathrm{MJS}=0.412 \mathrm{TF}=1.0 \mathrm{E}-9 \mathrm{PTF}=30$ )
.MODEL MN NMOS $(\operatorname{LEVEL}=3 \mathrm{VTO}=1.3 \mathrm{RS}=0.3 \mathrm{RD}=0.3$
+ TOX $=8.5 \mathrm{E}-8 \mathrm{LD}=1.48 \mathrm{E}-6 \mathrm{WD}=1 \mathrm{E}-6 \mathrm{NSUB}=1.53 \mathrm{E} 16 \mathrm{UO}=650$ DELTA $=10 \mathrm{VMAX}=2 \mathrm{E} 5$
$+\mathrm{XJ}=1.75 \mathrm{E}-6 \mathrm{KAPPA}=0.8 \mathrm{ETA}=0.066 \mathrm{THETA}=0.01 \mathrm{TPG}=1 \mathrm{CJ}=2.9 \mathrm{E}-4 \mathrm{~PB}=0.837$
$+\mathrm{MJ}=0.407 \mathrm{CJSW}=0.5 \mathrm{E}-9 \mathrm{MJSW}=0.33)$
.MODEL QP PNP(BF=61.5)
.MODEL DX D
.MODEL DZ D(BV=3.6)
.ENDS OP492



## FEATURES

Rail-to-Rail Output Swing
Single-Supply Operation: +3 V to 36 V
Low Offset Voltage: $\mathbf{3 0 0} \mu \mathrm{V}$
Gain Bandwidth Product: 75 kHz
High Open-Loop Gain: 1000 V/mV Unity-Gain Stable
Low Supply Current/Per Amplifier: $150 \boldsymbol{\mu A}$ max

## APPLICATIONS

Battery Operated Instrumentation
Servo Amplifiers
Actuator Drives
Sensor Conditioners
Power Supply Control

## GENERAL DESCRIPTION

Rail-to-rail output swing combined with dc accuracy are the key features of the OP-495 quad and OP-295 dual CBCMOS operational amplifiers. By using a bipolar front end, lower noise and higher accuracy than CMOS designs have been achieved. Both input and output ranges include the negative supply providing the user "zero-in/zero-out" capability. For users of 3.3 volt systems such as lithium batteries, the OP-295/OP-495 is specified for three volt operation.
Maximum offset voltage is specified at $300 \mu \mathrm{~V}$ for +5 volt operation, and the open-loop gain is a minimum of $1000 \mathrm{~V} / \mathrm{mV}$, giving the user performance that can be used to implement high accuracy systems even in single supply designs.
The ability to swing rail-to-rail and supply $\pm 15 \mathrm{~mA}$ to the load makes the OP-295/OP-495 an ideal driver for power transistors and " H " bridges. This allows designs to achieve higher efficiencies and to transfer more power to the load than previously possible without the use of discrete components. For applications that require driving inductive loads, such as transformers, increases in efficiency are also possible. Stability while driving capacitive loads is another benefit of this design over CMOS

## PIN CONNECTIONS



8-Lead Epoxy DIP
(P Suffix)

14-Lead Epoxy DIP (P Suffix)


16-Lead SOL (300 Mil) (S Suffix)

rail-to-rail amplifiers. This is useful for driving coax cable or large FET transistors. The OP-295/OP-495 is stable with loads in excess of 300 pF .
The OP-295 and OP-495 are specified over the extended industrial $\left(-40^{\circ} \mathrm{C}\right.$ to $\left.+125^{\circ} \mathrm{C}\right)$ temperature range. OP-295s are available in 8 -pin plastic and ceramic DIP plus SO-8 surface mount packages. OP-495s are available in 14-pin plastic and SOL-16 surface mount packages. Contact your local sales office for MIL-STD-883 data sheet.

ELECTRICAL CHARACTERISTICS
(@ $\mathrm{V}_{\mathrm{S}}=+5.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{CM}}=2.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT CHARACTERISTICS Offset Voltage Offset Voltage Input Bias Current Input Bias Current Input Offset Current Input Offset Current Input Voltage Range Common-Mode Rejection Large Signal Voltage Gain Large Signal Voltage Gain Offset Voltage Drift | $\begin{aligned} & \mathrm{V}_{\mathrm{Os}} \\ & \mathrm{~V}_{\mathrm{OS}} \\ & \mathrm{I}_{\mathrm{B}} \\ & \mathrm{I}_{\mathrm{B}} \\ & \mathrm{I}_{\mathrm{OS}} \\ & \mathrm{I}_{\mathrm{OS}} \\ & \mathrm{~V}_{\mathrm{CM}} \\ & \mathrm{CMR}^{2} \\ & \mathrm{~A}_{\mathrm{VO}} \\ & \mathrm{~A}_{\mathrm{VO}} \\ & \Delta \mathrm{~V}_{\mathrm{OS}} / \Delta \mathrm{T} \end{aligned}$ | $\begin{aligned} & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C} \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C} \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C} \\ & 0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CM}} \leq 4.0 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C} \\ & \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega, 0.005 \leq \mathrm{V}_{\text {OUT }} \leq 4.0 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega,-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C} \end{aligned}$ | $\begin{aligned} & 0 \\ & 90 \\ & 1000 \\ & 500 \end{aligned}$ | 30 <br> 8 <br> 1 <br> 110 <br> 10,000 <br> 1 | $\begin{aligned} & 300 \\ & 800 \\ & 20 \\ & 30 \\ & \pm 3 \\ & \pm 5 \\ & +4.0 \end{aligned}$ | $\mu \mathrm{V}$ <br> $\mu \mathrm{V}$ <br> nA <br> nA <br> nA <br> nA <br> V <br> dB <br> $\mathrm{V} / \mathrm{mV}$ <br> $\mathrm{V} / \mathrm{mV}$ <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| OUTPUT CHARACTERISTICS Output Voltage Swing High Output Voltage Swing High Output Voltage Swing Low Output Voltage Swing High Output Voltage Swing Low Output Voltage Swing Low Output Current | $\begin{aligned} & \mathrm{V}_{\mathrm{OH}} \\ & \mathrm{~V}_{\mathrm{OH}} \\ & \mathrm{~V}_{\mathrm{OH}} \\ & \mathrm{~V}_{\mathrm{OH}} \\ & \mathrm{~V}_{\mathrm{OL}} \\ & \mathrm{~V}_{\mathrm{OL}} \\ & \mathrm{I}_{\mathrm{OUT}} \end{aligned}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=100 \mathrm{k} \Omega \text { to } \mathrm{GND} \\ & \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \text { to } \mathrm{GND} \\ & \mathrm{I}_{\mathrm{OuT}}=1 \mathrm{~mA},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C} \\ & \mathrm{I}_{\mathrm{OUT}}=1 \mathrm{~mA},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C} \\ & \mathrm{R}_{\mathrm{L}}=100 \mathrm{k} \Omega \text { to } \mathrm{GND} \\ & \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \text { to } \mathrm{GND} \end{aligned}$ | 4.98 4.90 <br> 4.5 $\pm 11$ | $\begin{aligned} & 5.0 \\ & 4.94 \\ & \\ & 0.7 \\ & 0.7 \\ & \pm 18 \end{aligned}$ | 0.11 | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{mV} \\ & \mathrm{mV} \\ & \mathrm{~mA} \end{aligned}$ |
| POWER SUPPLY <br> Power Supply Rejection Ratio Power Supply Rejection Ratio Supply Current Per Amplifier | PSRR <br> PSRR <br> $\mathrm{I}_{\mathrm{SY}}$ | $\begin{aligned} & \pm 1.5 \mathrm{~V} \leq \mathrm{V}_{\mathrm{S}} \leq \pm 15 \mathrm{~V} \\ & \pm 1.5 \mathrm{~V} \leq \mathrm{V}_{\mathrm{S}} \leq \pm 15 \mathrm{~V}, \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\text {OUT }}=2.5^{\mathrm{V}}, \mathrm{R}_{\mathrm{L}}=\infty,-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C} \end{aligned}$ |  | 110 | 150 | dB <br> dB <br> $\mu \mathrm{A}$ |
| DYNAMIC PERFORMANCE <br> Slew Rate <br> Gain Bandwidth Product <br> Phase Margin | $\begin{aligned} & \text { SR } \\ & \text { GBP } \\ & \theta_{\mathrm{O}} \end{aligned}$ | $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ |  | $\begin{aligned} & 0.03 \\ & 75 \\ & 86 \end{aligned}$ |  | V/us <br> kHz <br> Degrees |
| NOISE PERFORMANCE Voltage Noise Voltage Noise Density Current Noise Density | $\begin{aligned} & \mathrm{e}_{\mathrm{n} p-\mathrm{p}} \\ & \mathrm{e}_{\mathrm{n}} \\ & \mathrm{i}_{\mathrm{n}} \\ & \hline \end{aligned}$ | $\begin{aligned} & 0.1 \mathrm{~Hz} \text { to } 10 \mathrm{~Hz} \\ & \mathrm{f}=1 \mathrm{kHz} \\ & \mathrm{f}=1 \mathrm{kHz} \end{aligned}$ |  | $\begin{aligned} & 1.5 \\ & 51 \\ & 0.6 \end{aligned}$ |  | $\begin{aligned} & \mu \mathrm{V} p-\mathrm{p} \\ & \mathrm{nV} / \sqrt{\mathrm{Hz}} \\ & \mathrm{pA} / \sqrt{\mathrm{Hz}} \\ & \hline \end{aligned}$ |

Specifications subject to change without notice.
ELECTRICAL CHARACTERISTICS (@ $\mathrm{v}_{\mathrm{S}}=+3.0 \mathrm{v}, \mathrm{v}_{\mathrm{CM}}=1.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT CHARACTERISTICS <br> Offset Voltage Input Bias Current Input Offset Current Input Voltage Range Common-Mode Rejection Large Signal Voltage Gain Offset Voltage Drift | $\mathrm{V}_{\mathrm{os}}$ <br> $\mathrm{I}_{\mathrm{B}}$ <br> $\mathrm{I}_{\mathrm{OS}}$ <br> $\mathrm{V}_{\mathrm{CM}}$ <br> CMR <br> $\mathrm{A}_{\mathrm{vo}}$ $\Delta \mathrm{V}_{\mathrm{OS}} / \Delta \mathrm{T}$ | $\begin{aligned} & 0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CM}} \leq 2.0 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C} \\ & \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \end{aligned}$ |  | $\begin{aligned} & 100 \\ & 8 \\ & 1 \\ & 110 \\ & 750 \\ & 1 \end{aligned}$ | $\begin{aligned} & 500 \\ & 20 \\ & \pm 3 \\ & +2.0 \end{aligned}$ | $\mu \mathrm{V}$ nA nA V dB $\mathrm{V} / \mathrm{mV}$ $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| OUTPUT CHARACTERISTICS Output Voltage Swing High Output Voltage Swing Low | $\begin{aligned} & \mathrm{v}_{\mathrm{OH}} \\ & \mathrm{v}_{\mathrm{OL}} \end{aligned}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \text { to } \mathrm{GND} \\ & \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \text { to } \mathrm{GND} \end{aligned}$ | 2.9 | 0.7 | 2 | $\begin{aligned} & \mathrm{V} \\ & \mathrm{mV} \end{aligned}$ |
| POWER SUPPLY <br> Power Supply Rejection Ratio Power Supply Rejection Ratio Supply Current Per Amplifier | $\begin{aligned} & \text { PSRR } \\ & \text { PSRR } \\ & I_{\text {SY }} \end{aligned}$ | $\begin{aligned} & \pm 1.5 \mathrm{~V} \leq \mathrm{V}_{\mathrm{S}} \leq \pm 15 \mathrm{~V} \\ & \pm 1.5 \mathrm{~V} \leq \mathrm{V}_{\mathrm{S}} \leq \pm 15 \mathrm{~V}, \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\text {OUT }}=1.5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=\infty,-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C} \end{aligned}$ | $\begin{aligned} & 90 \\ & 85 \end{aligned}$ | 110 | 150 | dB <br> dB <br> $\mu \mathrm{A}$ |
| DYNAMIC PERFORMANCE <br> Slew Rate Gain Bandwidth Product Phase Margin | $\begin{aligned} & \text { SR } \\ & \text { GBP } \\ & \theta_{\mathrm{O}} \end{aligned}$ | $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ |  | $\begin{aligned} & 0.03 \\ & 75 \\ & 85 \\ & \hline \end{aligned}$ |  | V/us <br> kHz <br> Degrees |
| NOISE PERFORMANCE <br> Voltage Noise Voltage Noise Density Current Noise Density | $\begin{aligned} & e_{n p-p} \\ & e_{n} \\ & i_{n} \\ & \hline \end{aligned}$ | $\begin{aligned} & 0.1 \mathrm{~Hz} \text { to } 10 \mathrm{~Hz} \\ & \mathrm{f}=1 \mathrm{kHz} \\ & \mathrm{f}=1 \mathrm{kHz} \end{aligned}$ | $\because$ | $\begin{aligned} & 1.6 \\ & 53 \\ & 0.6 \\ & \hline \end{aligned}$ |  | $\mu \mathrm{V}$ p-p $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |

Specifications subject to change without notice.

## Electrical Characteristics <br> (@ $V_{S}= \pm 15.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT CHARACTERISTICS Offset Voltage Offset Voltage Input Bias Current Input Bias Current Input Offset Current Input Offset Current Input Voltage Range Common-Mode Rejection Large Signal Voltage Gain Offset Voltage Drift | $\mathrm{V}_{\text {os }}$ <br> $V_{\text {os }}$ <br> $\mathrm{I}_{\mathrm{B}}$ <br> $\mathrm{I}_{\mathrm{B}}$ <br> $\mathrm{I}_{\mathrm{os}}$ <br> $\mathrm{I}_{\mathrm{OS}}$ <br> $\mathrm{V}_{\mathrm{CM}}$ <br> CMR <br> $\mathrm{A}_{\mathrm{vo}}$ <br> $\Delta V_{o s} / \Delta T$ | $\begin{aligned} & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C} \\ & -15.0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CM}} \leq+13.5 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C} \\ & \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \end{aligned}$ | $\begin{aligned} & -15 \\ & 90 \\ & 1000 \end{aligned}$ | 300 <br> 7 <br> 1 <br> 110 <br> 4000 <br> 1 | $\begin{aligned} & 500 \\ & 800 \\ & 20 \\ & 30 \\ & \pm 3 \\ & \pm 5 \\ & +13.5 \end{aligned}$ | $\mu \mathrm{V}$ <br> $\mu \mathrm{V}$ <br> nA <br> nA <br> nA <br> nA <br> V <br> dB <br> V/mV <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| OUTPUT CHARACTERISTICS Output Voltage Swing High Output Voltage Swing High Output Voltage Swing Low Output Voltage Swing Low Output Current | $\mathrm{V}_{\mathrm{OH}}$ <br> $\mathrm{V}_{\mathrm{OH}}$ <br> $\mathrm{V}_{\text {OL }}$ <br> $\mathrm{V}_{\text {OL }}$ <br> $\mathrm{I}_{\text {OUT }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=100 \mathrm{k} \Omega \text { to } \mathrm{GND} \\ & \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \text { to } \mathrm{GND} \\ & \mathrm{R}_{\mathrm{L}}=100 \mathrm{k} \Omega \text { to } \mathrm{GND} \\ & \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \text { to } \mathrm{GND} \end{aligned}$ | $\begin{aligned} & 14.95 \\ & 14.80 \\ & \pm 15 \end{aligned}$ | $\pm 25$ | $\begin{aligned} & -14.95 \\ & -14.85 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~mA} \end{aligned}$ |
| POWER SUPPLY <br> Power Supply Rejection Ratio Power Supply Rejection Ratio Supply Current Supply Voltage Range | PSRR <br> PSRR <br> $I_{S Y}$ <br> $\mathrm{V}_{\mathrm{s}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}= \pm 1.5 \mathrm{~V} \text { to } \pm 15 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 1.5 \mathrm{~V} \text { to } \pm 15 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{O}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=\infty, \mathrm{V}_{\mathrm{S}}= \pm 18 \mathrm{~V}, \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C} \end{aligned}$ | $\begin{aligned} & 90 \\ & 85 \\ & +3( \pm 15) \end{aligned}$ | $110$ | $\begin{aligned} & 175 \\ & +36( \pm 18) \end{aligned}$ | dB dB <br> $\mu \mathrm{A}$ <br> V |
| DYNAMIC PERFORMANCE <br> Slew Rate <br> Gain Bandwidth Product Phase Margin | SR <br> GBP <br> $\theta_{\mathrm{O}}$ | $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ |  | $\begin{aligned} & 0.03 \\ & 85 \\ & 83 \end{aligned}$ |  | V/us <br> kHz <br> Degrees |
| NOISE PERFORMANCE <br> Voltage Noise Voltage Noise Density Current Noise Density |  | $\begin{aligned} & 0.1 \mathrm{~Hz} \text { to } 10 \mathrm{~Hz} \\ & \mathrm{f}=1 \mathrm{kHz} \\ & \mathrm{f}=1 \mathrm{kHz} \end{aligned}$ |  | $\begin{aligned} & 1.25 \\ & 45 \\ & 0.6 \end{aligned}$ |  | $\mu \mathrm{V}$ p-p $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ $\mathrm{pA} / \sqrt{ } \mathrm{Hz}$ |

Specifications subject to change without notice.
WAFER TEST LIMITS (@ $\mathrm{v}_{\mathrm{s}}=+5.0 \mathrm{v}, \mathrm{v}_{\mathrm{cm}}=2.5 \mathrm{v}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless othenise noted)

| Parameter | Symbol | Conditions | Limit | Units |
| :---: | :---: | :---: | :---: | :---: |
| Offset Voltage | $\mathrm{V}_{\text {Os }}$ |  | 300 | $\mu \mathrm{V}$ max |
| Input Bias Current | $\mathrm{I}_{\text {B }}$ |  | 20 | $n A \max$ |
| Input Offset Current | $\mathrm{I}_{\text {OS }}$ |  | $\pm 2$ | $n A$ max |
| Input Voltage Range ${ }^{1}$ | $\mathrm{V}_{\mathrm{CM}}$ |  | 0 to +4 | $V$ min |
| Common-Mode Rejection | CMRR | $0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CM}} \leq 4 \mathrm{~V}$ | 90 | dB min |
| Power Supply Rejection Ratio | PSRR | $\pm 1.5 \mathrm{~V} \leq \mathrm{V}_{\mathrm{S}} \leq \pm 15 \mathrm{~V}$ | 90 | $\mu \mathrm{V} / \mathrm{V}$ |
| Large Signal Voltage Gain | $\mathrm{A}_{\text {vo }}$ | $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ | 1000 | $\mathrm{V} / \mathrm{mV}$ min |
| Output Voltage Swing High | $\mathrm{V}_{\mathrm{OH}}$ | $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ | 4.9 | $V \min$ |
| Supply Current Per Amplifier | $\mathrm{I}_{\text {SY }}$ | $\mathrm{V}_{\text {OUT }}=2.5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=\infty$ | 150 | $\mu \mathrm{A}$ max |

NOTES
Electrical tests and wafer probe to the limits shown. Due to variations in assembly methods and normal yield loss, yield after packaging is not guaranteed for standard product dice. Consult factory to negotiate specifications based on dice lot qualifications through sample lot assembly and testing.
${ }^{1}$ Guaranteed by CMR test.

## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| OP295GP | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8 8-Pin Plastic DIP | N-8 |
| OP295GS | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Pin SOIC | SO-8 |
| OP295GBC | $+25^{\circ} \mathrm{C}$ | DICE |  |


| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| OP495GP | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 14-Pin Plastic DIP | N-14 |
| OP495GS | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 16-Pin SOL | R-16 |
| OP495GBC | $+25^{\circ} \mathrm{C}$ | DICE |  |

$\star$ For outline information see Package Information section.

| ABSOLUTE MAXIMUM RATINGS ${ }^{1}$ |  |
| :---: | :---: |
| Supply Voltage | 8 V |
| Input Voltage ${ }^{2}$ | $\pm 18 \mathrm{~V}$ |
| Differential Input Voltage ${ }^{2}$ | 36 V |
| Output Short-Circuit Duration | Indefinite |
| Storage Temperature Range |  |
| P, S Package | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Operating Temperature Range |  |
| OP-295G, OP-495G | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Junction Temperature Range |  |
| P, S Package | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Lead Temperature Range (Soldering, 60 Sec ) | $+300^{\circ} \mathrm{C}$ |


| Package Type | $\boldsymbol{\theta}_{\mathbf{J A}}{ }^{\mathbf{3}}$ | $\boldsymbol{\theta}_{\mathbf{J C}}$ | Units |
| :--- | :--- | :--- | :--- |
| 8-Pin Plastic DIP (P) | 103 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin SOIC (S) | 158 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 14-Pin Plastic DIP (P) | 83 | 39 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 16-Pin SOL (S) | 98 | 30 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTES

${ }^{1}$ Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
${ }^{2}$ For supply voltages less than $\pm 18 \mathrm{~V}$, the absolute maximum input voltage is equal to the supply voltage.
${ }^{3} \theta_{\mathrm{JA}}$ is specified for the worst case conditions, i.e., $\theta_{\mathrm{JA}}$ is specified for device in socket for cerdip, P-DIP, and LCC packages; $\theta_{\mathrm{JA}}$ is specified for device soldered in circuit board for SOIC package.

## DICE CHARACTERISTICS



OP-295 Die Size $0.066 \times 0.080$ inch, 5,280 sq. mils.
Substrate (Die Backside) Is Connected to V+.
Transistor Count, 74.


OP-495 Die Size $0.113 \times 0.083$ inch, 9,380 sq. mils. Substrate (Die Backside) Is Connected to V+. Transistor Count, 196.

## Typical Characteristics-OP295/0P495



Supply Current Per Amplifier vs. Temperature


Output Voltage Swing vs. Temperature

## OP295/OP495-Typical Characteristics



Output Voltage Swing vs. Temperature


OP-295 Input Offset ( $V_{\text {os }}$ ) Distribution


OP-295 $T_{C}-V_{\text {OS }}$ Distribution


Output Voltage Swing vs. Temperature


OP-495 Input Offset ( $V_{\text {OS }}$ ) Distribution


OP-495 $T_{C}-V_{O S}$ Distribution


Input Bias Current vs. Temperature


Output Current vs. Temperature


Open-Loop Gain vs. Temperature


Open-Loop Gain vs. Temperature


Output Voltage to Supply Rail vs. Sink and Source Load Current

## APPLICATIONS

## Rail-to-Rail Applications Information

The OP-295/OP-495 has a wide common-mode input range extending from ground to within about 800 mV of the positive supply. There is a tendency to use the OP-295/OP-495 in buffer applications where the input voltage could exceed the commonmode input range. This may initially appear to work because of the high input range and rail-to-rail output range. But above the common-mode input range the amplifier is, of course, highly nonlinear. For this reason it is always required that there be some minimal amount of gain when rail-to-rail output swing is desired. Based on the input common-mode range this gain should be at least 1.2.

## Low Drop-Out Reference

The OP-295/OP-495 can be used to gain up a 2.5 V or other low voltage reference to 4.5 volts for use with high resolution $\mathrm{A} / \mathrm{D}$ converters that operate from +5 volt only supplies. The circuit in Figure 1 will supply up to 10 mA . Its no-load drop-out voltage is only 20 mV . This circuit will supply over 3.5 mA with a +5 volt supply.


Figure 1. 4.5 Volt, Low Drop-Out Reference

## Low Noise, Single Supply Preamplifier

Most single supply op amps are designed to draw low supply current, at the expense of having higher voltage noise. This tradeoff may be necessary because the system must be powered by a battery. However, this condition is worsened because all circuit resistances tend to be higher, as a result, in addition to the op amp's voltage noise, Johnson noise (resistor thermal noise) is also a significant contributor to the total noise of the system.
The choice of monolithic op amps that combine the characteristics of low noise and single supply operation is rather limited. Most single supply op amps have noise on the order of 30 to $60 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ and single supply amplifiers with noise below $5 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ do not exist.
In order to achieve both low noise and low supply voltage operation, discrete designs may provide the best solution. The circuit on Figure 2 uses the OP-295/OP-495 rail-to-rail amplifier and a matched PNP transistor pair - the MAT03 - to achieve zero-in/ zero-out single supply operation with an input voltage noise of $3.1 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ at 100 Hz . R5 and R6 set the gain of 1000 , making this circuit ideal for maximizing dynamic range when amplifying low level signals in single supply applications. The OP-295/ OP-495 provides rail-to-rail output swings allowing this circuit to operate with 0 to 5 volt outputs. Only half of the OP-295/ OP-495 is used leaving the other uncommitted op amp for use elsewhere.


Figure 2. Low Noise Single Supply Preamplifier
The input noise is controlled by the MAT-03 transistor pair and its collector current level. Increasing the collector current reduces the voltage noise. This particular circuit was tested with 1.85 mA and 0.5 mA of current. Under these two cases, the input voltage noise was $3.1 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ and $10 \mathrm{nV} / \sqrt{\mathrm{Hz}}$, respectively. The high collector currents do lead to a tradeoff in supply current, bias current, and current noise. All of these parameters will increase with increasing collector current. For example, typically the MAT-03 has an $\mathrm{h}_{\mathrm{FE}}=165$. This leads to bias currents of $11 \mu \mathrm{~A}$ and $3 \mu \mathrm{~A}$, respectively. Based on high bias currents, this circuit is best suited for applications with low source impedance such as magnetic pickups or low impedance strain gauges. Furthermore, a high source impedance will degrade the noise performance. For example, a $1 \mathrm{k} \Omega$ resistor generates $4 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ of broad band noise, which is already greater than the preamp.
The collector current is set by R1 in combination with the LED and Q2. The LED is a 1.6 V "Zener" that has temperature coefficient close to that of Q2's base-emitter junction, which provides a constant 1.0 V drop across R1. With R1 equal to $270 \Omega$, the tail current is 3.7 mA , and the collector current is half that or 1.85 mA . The value of R1 can be altered to adjust the collector current. Whenever R1 is changed, R3 and R4 should also be adjusted. To maintain a common-mode input range that includes ground, the collectors of the Q1 and Q2 should not go above 0.5 V , otherwise they could saturate. Thus, R3 and R4 have to be small enough to prevent this condition. Their values and the overall performance for two different values of R1 are summarized in Table I. Lastly, the potentiometer, R8, is needed to adjust the offset voltage to null it to zero. Similar performance can be obtained using an OP-90 as the output amplifier with a savings of about $185 \mu \mathrm{~A}$ of supply current. However, the output swing will not include the positive rail, and the bandwidth will reduce to approximately 250 Hz .

Table I. Single Supply Low Noise Preamp Performance

|  | $\mathbf{I}_{\mathbf{C}}=\mathbf{1 . 8 5} \mathbf{~ m A}$ | $\mathbf{I}_{\mathbf{C}}=\mathbf{0 . 5 \mathrm { mA }}$ |
| :--- | :--- | :--- |
| R 1 | $270 \Omega$ | $1.0 \mathrm{k} \Omega$ |
| $\mathrm{R} 3, \mathrm{R4}$ | $200 \Omega$ | $910 \Omega \Omega$ |
| $\mathrm{e}_{\mathrm{n}}(11100 \mathrm{~Hz}$ | $3.15 \mathrm{nV} / \backslash \overline{\mathrm{Hz}}$ | $8.6 \mathrm{nV} / \backslash \overline{\mathrm{Hz}}$ |
| $\mathrm{e}_{\mathrm{n}}(1110 \mathrm{~Hz}$ | $4.2 \mathrm{nV} / \backslash \overline{\mathrm{Hz}}$ | $10.2 \mathrm{nV} / \backslash \overline{\mathrm{Hz}}$ |
| $\mathrm{I}_{\mathrm{SY}}$ | 4.0 mA | 1.3 mA |
| $\mathrm{I}_{\mathrm{B}}$ | $11 \mu \mathrm{~A}$ | $3 \mu \mathrm{~A}$ |
| Bandwidth | 1 kHz | 1 kHz |
| Closed-Loop Gain | 1000 | 1000 |

## Driving Heavy Loads

The OP-295/OP-495 is well suited to drive loads by using a power transistor, Darlington or FET to increase the current to the load. The ability to swing to either rail can assure that the device is turned on hard. This results in more power to the load and an increase in efficiency over using standard op amps with their limited output swing. Driving power FETs is also possible with the OP-295/OP-495 because of its ability to drive capacitive loads of several hundred picofarads without oscillating.
Without the addition of external transistors the OP-295/OP-495 can drive loads in excess of $\pm 15 \mathrm{~mA}$ with $\pm 15$ or 30 volt supplies. This drive capability is somewhat decreased at lower supply voltages. At $\pm 5$ volt supplies the drive current is $\pm 11 \mathrm{~mA}$.
Driving motors or actuators in two directions, in a single supply application is often accomplished using an "H" bridge. The principle is demonstrated in Figure 3a. From a single +5 volt supply this driver is capable of driving loads from 0.8 to 4.2 volts in both directions. Figure 3b shows the voltages at the inverting and noninverting outputs of the driver. There is a small crossover glitch that is frequency dependent and would


Figure 3a. " H " Bridge


Figure 3b. " $H$ " Bridge Outputs
not cause problems unless this was a low distortion application such as audio. If this is used to drive inductive loads, be sure to add diode clamps to protect the bridge from inductive kickback.

## Direct Access Arrangement

OP-295/OP-495 can be used in a single supply Direct Access Arrangement (DAA) as is shown in Figure 4. This figure shows a portion of a typical DAA capable of operating from a single +5 volt supply and it may also work on +3 volt supplies with minor modifications. Amplifiers A2 and A3 are configured so that the transmit signal TXA is inverted by A2 and is not inverted by A3. This arrangement drives the transformer differentially so that the drive to the transformer is effectively doubled over a single amplifier arrangement. This application takes advantage of the OP-295/OP-495's ability to drive capacitive loads, and to save power in single supply applications.


Figure 4. Direct Access Arrangement

## A Single Supply Instrumentation Amplifier

The OP-295/OP-495 can be configured as a single supply instrumentation amplifier as in Figure 5. The input common-mode voltage range includes ground and the output swings to both rails.


Figure 5. Single Supply Instrumentation Amplifier
Resistor $\mathbf{R}_{\mathrm{G}}$ sets the gain of the instrumentation amplifier. Minimum gain is 6 (with no $R_{G}$ ). All resistors should be matched in absolute value as well as temperature coefficient to maximize common-mode rejection performance and minimize drift. This instrumentation amplifier can operate from a supply voltage as low as 3 volts.

## OP295/0P495

## A Single Supply RTD Thermometer Amplifier

This RTD amplifier takes advantage of the rail-to-rail swing of the OP-295/OP-495 to achieve a high bridge voltage in spite of a low 5 V supply. The OP-295/OP-495 amplifier servos a constant $200 \mu \mathrm{~A}$ current to the bridge. The return current drops across the parallel resistors $6.19 \mathrm{k} \Omega$ and the $2.55 \mathrm{M} \Omega$, developing a voltage that is servoed to 1.235 V , which is established by the AD589 bandgap reference. The 3 -wire RTD provides a equal line resistance drop in both $100 \Omega$ legs of the bridge, thus improving the accuracy.
The AMP-04 amplifies the differential bridge signal and converts it to a single-ended output. The gain is set by the series resistance of the $332 \Omega$ resistor plus the $50 \Omega$ potentiometer. The gain scales the output to produce a 4.5 V full scale. The $0.22 \mu \mathrm{~F}$ capacitor to the output provides a 7 Hz low-pass filter to keep noise at a minimum.


Figure 6. Low Power RTD Amplifier

## A Cold Junction Compensated, Battery Powered Thermocouple Amplifier

The OP-295/OP-495's $150 \mu \mathrm{~A}$ quiescent current per amplifier consumption makes it useful for battery powered temperature measuring instruments. The K-type thermocouple terminates into an isothermal block where the terminated junctions' ambient temperature can be continuously monitored and corrected by summing an equal but opposite thermal EMF to the amplifier, thereby canceling the error introduced by the cold junctions.
To calibrate, immerse the thermocouple measuring junction in a $0^{\circ} \mathrm{C}$ ice bath, adjust the $500 \Omega$ Zero Adjust pot to zero volts out. Then immerse the thermocouple in a $250^{\circ} \mathrm{C}$ temperature bath or oven and adjust the Scale Adjust pot for an output voltage of 2.50 V , which is equivalent to $250^{\circ} \mathrm{C}$. Within this temperature


Figure 7. Battery Powered, Cold-Junction Compensated Thermocouple Amplifier
range, the K-type thermocouple is quite accurate and produces a fairly linear transfer characteristic. Accuracy of $\pm 3^{\circ} \mathrm{C}$ is achievable without linearization.

Even if the battery voltage is allowed to decay to as low as 7 volts, the rail-to-rail swing allows temperature measurements to $700^{\circ} \mathrm{C}$. However, linearization may be necessary for temperatures above $250^{\circ} \mathrm{C}$ where the thermocouple becomes rather nonlinear. The circuit draws just under $500 \mu \mathrm{~A}$ supply current from a 9 V battery.

## A 5 V Only, 12-Bit DAC That Swings 0 V to 4.095 V

Figure 8 shows a complete voltage output DAC with wide output voltage swing operating off a single +5 V supply. The serial input 12 -bit $\mathrm{D} / \mathrm{A}$ converter is configured as a voltage output device with the 1.235 V reference feeding the current output pin ( $\mathrm{I}_{\text {OUT }}$ ) of the DAC. The $\mathrm{V}_{\text {REF }}$ which is normally the input, now becomes the output.
The output voltage from the DAC is the binary weighted voltage of the reference, which is gained up by the output amplifier such that the DAC has a 1 mV per bit transfer function.


Figure 8. A 5 Volt 12-Bit DAC with $0 V$ to +4.095 Output Swing

## 4-20mA Current Loop Transmitter

Figure 9 shows a self-powered $4-20 \mathrm{~mA}$ current loop transmitter. The entire circuit floats up from the single supply ( 12 V to 36 V ) return. The supply current carries the signal within the 4 mA to 20 mA range. Thus the 4 mA establishes the baseline


Figure 9. 4-20 mA Current Loop Transmitter
current budget with which the circuit must operate. This circuit consumes only 1.4 mA maximum quiescent current, making 2.6 mA of current available to power additional signal conditioning circuitry or to power a bridge circuit.

## A 3 Volt Low-Dropout Linear Voltage Regulator

Figure 10 shows a simple 3 V voltage regulator design. The regulator can deliver 50 mA load current while allowing a 0.2 V dropout voltage. The OP-295/OP-495's rail-to-rail output swing handily drives the MJE350 pass transistor without requiring special drive circuitry. At no load, its output can swing less than the pass transistor's base-emitter voltage, turning the device nearly off. At full load, and at low emitter-collector voltages, the transistor beta tends to decrease. The additional base current is easily handled by the OP-295/OP-495 output.

The amplifier servos the output to a constant voltage, which feeds a portion of the signal to the error amplifier.
Higher output current, to 100 mA , is achievable at a higher dropout voltage of 3.8 V .


Figure 10. 3 V Low Dropout Voltage Regulator
Figure 11 shows the regulator's recovery characteristic when its output underwent a 20 mA to 50 mA step current change.


Figure 11. Output Step Load Current Recovery

## Low Dropout, $\mathbf{5 0 0} \mathrm{mA}$ Voltage Regulator with Fold-Back Current Limiting

Adding a second amplifier in the regulation loop as shown in Figure 12 provides an output current monitor as well as provides fold-back current limiting protection.
Amplifier Al provides error amplification for the normal voltage regulation loop. As long as the output current is less than 1 ampere, amplifier A2's output swings to ground, reverse biasing the diode and effectively taking itself out of the circuit. However, as the output current exceeds 1 amp , the voltage that
develops across the $0.1 \Omega$ sense resistor forces the amplifier A2's output to go high, forward-biasing the diode, which in turn closes the current limit loop. At this point A2's lower output resistance dominates the drive to the power MOSFET transistor, thereby effectively removing the Al voltage regulation loop from the circuit.
If the output current greater than 1 amp persists, the current limit loop forces a reduction of current to the load, which causes a corresponding drop in output voltage. As the output voltage drops, the current limit threshold also drops fractionally, resulting in a decreasing output current as the output voltage decreases, to the limit of less than 0.2 A at 1 V output. This "fold-back" effect reduces the power dissipation considerably during a short circuit condition, thus making the power supply far more forgiving in terms of the thermal design requirements. Small heat sinking on the power MOSFET can be tolerated.
The OP-295's rail-to-rail swing exacts higher gate drive to the power MOSFET, providing a fuller enhancement to the transistor. The regulator exhibits 0.2 V drop-out at 500 mA of load current. At 1 amp output, the drop-out voltage is typically 5.6 volts.


Figure 12. Low Dropout, 500 mA Voltage Regulator with Fold-back Current Limiting

## Square Wave Oscillator

The oscillator circuit in Figure 13 shows the rail-to-rail swing helps maintain a constant oscillation frequency even though the supply voltage varies considerably. This works great in a battery powered system where no voltage regulation is required. The constant frequency comes from the fact that the $58.7 \mathrm{k} \Omega$ feedback sets up Schmitt Trigger threshold levels that are directly proportional to the supply voltage, as are the RC charge voltage levels. As a result, the RC charge time, and therefore the frequency, remain constant independent of supply voltage. The slew rate of the amplifier limits the oscillation frequency to a maximum of about 800 Hz at +5 V supply.

## Single Supply Differential Speaker Driver

Connected as a differential speaker driver, the OP-295/OP-495 can deliver a minimum of 10 mA to the load. With a $600 \Omega$ load, the OP-295/OP-495 can swing close to 5 volts peak-to-peak across the load.


Figure 13. Square Wave Oscillator Has Stable Frequency Regardless of Supply Changes


Figure 14. Single Supply Differential Speaker Driver

High Accuracy, Single Supply, Low Power Comparator The OP-295/OP-495 makes an accurate open-loop comparator. With single +5 V supply, the offset error is less than $300 \mu \mathrm{~V}$. Figure 15 shows the OP-295/OP495's response time operating open-loop with 4 mV overdrive. It exhibits a 4 ms response time at the rising edge and a 1.5 ms response time at the falling edge.


Figure 15. Open-Loop Comparator Response Time with 5 mV Overdrive

## OP-295/OP-495 SPICE MODEL Macro-Model

* Node Assignments

* InPut STAGE

| II | 99 | 4 | $2 \mathrm{E}-6$ |  |
| :--- | :--- | :--- | :--- | :--- |
| R1 | 1 | 6 | 5 E 3 |  |
| R2 | 2 | 5 | 5 E 3 |  |
| CIN | 1 | 2 | $2 \mathrm{E}-12$ |  |
| IOS | 1 | 2 | $0.5 \mathrm{E}-9$ |  |
| D1 | 5 | 3 | DZ |  |
| D2 | 6 | 3 | DZ |  |
| VOS | 7 | 6 | $30 \mathrm{E}-6$ |  |
| Q1 | 8 | 5 | 4 | QP |
| Q2 | 9 | 7 | 4 | QP |
| R3 | 8 | 50 | 25.8 E 3 |  |
| R4 | 9 | 50 | 25.8 E 3 |  |

* Galn Stage
$+\mathrm{XJ}=1.75 \mathrm{E}-6 \mathrm{KAPPA}=0.8 \mathrm{ETA}=0.066 \mathrm{THETA}=0.01 \mathrm{TPG}=1 \mathrm{CJ}=2.9 \mathrm{E}-4$ $\mathrm{PB}=0.837$
$+\mathrm{MJ}=0.407 \mathrm{CJSW}=0.5 \mathrm{E}-9 \mathrm{MJSW}=0.33$ )
.MODEL MP PMOS (LEVEL=3 VTO $=-1.1 \mathrm{RS}=0.7 \mathrm{RD}=0.7$
$+\mathrm{TOX}=9.5 \mathrm{E}-8 \mathrm{LD}=1.4 \mathrm{E}-6 \mathrm{WD}=1 \mathrm{E}-6 \mathrm{NSUB}=2.4 \mathrm{E} 15 \mathrm{UO}=650 \mathrm{DELTA}=5.6$
VMAX $=1 \mathrm{E} 5$
$+\mathrm{XJ}=1.75 \mathrm{E}-6 \mathrm{KAPPA}=1.7 \mathrm{ETA}=0.71 \mathrm{THETA}=5.9 \mathrm{E}-3 \quad \mathrm{TPG}=-1 \mathrm{CJ}=1.55 \mathrm{E}-4$ $\mathrm{PB}=0.56$
$+\mathrm{MJ}=0.442 \mathrm{CJSW}=0.4 \mathrm{E}-9 \mathrm{MJSW}=0.33$ )
.MODEL DX D(IS = $1 \mathrm{E}-15$ )
.MODEL DZ D (IS=1E-15, BV=7)
. $\operatorname{MODEL}$ QP PNP $(\mathrm{BF}=125)$
.ENDS OP-295/OP-495

R7 $\quad \begin{array}{lll}10 & 98 & 270 \mathrm{E} 6\end{array}$
G1 $\quad 98 \quad 10 \quad(9,8,27.8 \mathrm{E}-6$
$\begin{array}{llll}\text { EREF } & 98 & 0 & (39,0) 1\end{array}$
$\begin{array}{lllll}\text { R5 } & 99 & 39 & \text { l00E3 }\end{array}$
R6 $\quad 39 \quad 50 \quad 100 \mathrm{E} 3$

* OLTPL'T STAGE

I2 $\quad 18 \quad 50 \quad 1.59 \mathrm{E}-6$
V2 $\quad 99 \quad 12 \quad$ DC 2.2763
Q+ $\quad \begin{array}{lllll}10 & 1+ & 50 & \text { QNA } & 1.0\end{array}$
$\begin{array}{lllllll}\mathrm{M} 3 & 15 & 50 & 33 & & & \\ \mathrm{M} & 13 & 13 & \mathrm{MN} & \mathrm{L}=9 \mathrm{E}-6 \quad \mathrm{~W}=102 \mathrm{E}-6 \mathrm{AD}=15 \mathrm{E}-10 \mathrm{AD}=15 \mathrm{E}-10\end{array}$
M4 $\quad 13 \quad 10 \quad 50 \quad 50 \quad \mathrm{MN} \quad \mathrm{L}=9 \mathrm{E}-6 \quad \mathrm{~W}=50 \mathrm{E}-6 \mathrm{AD}=75 \mathrm{E}-11 \mathrm{AS}=75 \mathrm{E}-11$
D8 $\quad \begin{array}{lll}10 & 22 & \mathrm{DX}\end{array}$
V3 $\quad 22 \quad 50$ DC 6
M2 $20 \quad 10$ 14 14 MN $\mathrm{L}=9 \mathrm{E}-6 \mathrm{~W}=2000 \mathrm{E}-6 \mathrm{AD}=30 \mathrm{E}-9 \mathrm{AS}=30 \mathrm{E}-9$
$\begin{array}{llllll}\text { Q5 } & 17 & 17 & 99 & \text { QPA } & 1.0\end{array}$
$\begin{array}{llllll}\text { Q6 } & 18 & 17 & 99 & \text { QPA } & 4.0\end{array}$
$\begin{array}{llll}\text { R8 } & 18 & 99 & 2.2 \mathrm{E} 6\end{array}$
$\begin{array}{llllll}\text { Q7 } & 18 & 19 & 99 & \text { QPA } & 1.0\end{array}$
$\begin{array}{llll}\text { R9 } & 99 & 19 & 8\end{array}$
$\begin{array}{llll}\mathrm{C} 2 & 18 & 99 & 20 \mathrm{E}-12\end{array}$
M6 $\quad 15 \quad 12 \quad 17 \quad 99 \quad \mathrm{MP} \quad \mathrm{L}=9 \mathrm{E}-6 \mathrm{~W}=27 \mathrm{E}-6 \mathrm{AD}=405 \mathrm{E}-12 \quad \mathrm{AS}=405 \mathrm{E}-12$
M1 $20 \quad 18 \quad 19 \quad 99 \quad \mathrm{MP} \quad \mathrm{L}=9 \mathrm{E} \quad \mathrm{W}=2000 \mathrm{E}-6 \mathrm{AD}=30 \mathrm{E}-9 \mathrm{AS}=30 \mathrm{E}-9$
D4 $\quad 21 \quad 18$ DX
V4 $\quad 99 \quad 21$ DC 6
$\begin{array}{llll}\text { R10 } & 10 & 11 & 6 \mathrm{E} 3\end{array}$
C3 $\quad 11 \quad 20 \quad 50 \mathrm{E}-12$
.MODEL QNA NPN (IS $=1.19 \mathrm{E}-16 \mathrm{BF}=253 \mathrm{NF}=0.99 \mathrm{VAF}=193 \mathrm{IKF}=2.76 \mathrm{E}-3$
$+1 \mathrm{SE}=2.57 \mathrm{E}-13 \mathrm{NE}=5 \mathrm{BR}=0.4 \mathrm{NR}=0.988 \mathrm{VAR}=15 \mathrm{IKR}=1.465 \mathrm{E}-4$
$+\mathrm{ISC}=6.9 \mathrm{E}-16 \mathrm{NC}=0.99 \mathrm{RB}=2.0 \mathrm{E} 3$ IRB $=7.73 \mathrm{E}-6 \mathrm{RBM}=132.8 \mathrm{RE}=4 \mathrm{RC}=209$
$+\mathrm{CJE}=2.1 \mathrm{E}-13 \mathrm{VJE}=0.573 \mathrm{MJE}=0.364 \mathrm{FC}=0.5 \mathrm{CJC}=1.64 \mathrm{E}-13 \mathrm{VJC}=0.534$ MJC=0.5
$+\mathrm{CJS}=1.37 \mathrm{E}-12 \mathrm{VJS}=0.59 \mathrm{MJS}=0.5 \mathrm{TF}=0.43 \mathrm{E}-9 \mathrm{PTF}=30$ )
.MODEL QPA PNP (IS $=5.21 \mathrm{E}-17 \mathrm{BF}=131 \mathrm{NF}=0.99 \mathrm{VAF}=62 \mathrm{IKF}=8.35 \mathrm{E}-4$
$+\mathrm{ISE}=1.09 \mathrm{E}-14 \mathrm{NE}=2.61 \mathrm{BR}=0.5 \mathrm{NR}=0.984 \mathrm{VAR}=15 \mathrm{IKR}=3.96 \mathrm{E}-5$
$+\mathrm{ISC}=7.58 \mathrm{E}-16 \mathrm{NC}=0.985 \mathrm{RB}=1.52 \mathrm{E} 3 \mathrm{IRB}=1.67 \mathrm{E}-5 \mathrm{RBM}=368.5 \mathrm{RE}=6.31$
RC=354.4
$+\mathrm{CJE}=1.1 \mathrm{E}-13 \mathrm{VJE}=0.745 \mathrm{MJE}=0.33 \mathrm{FC}=0.5 \mathrm{CJC}=2.37 \mathrm{E}-13 \mathrm{VJC}=0.762$
MJC=0.4
$+\mathrm{CJS}=7.11 \mathrm{E}-13 \mathrm{VJS}=0.45 \mathrm{MJS}=0.412 \mathrm{TF}=1.0 \mathrm{E}-9 \mathrm{PTF}=30$ )
.MODEL MN NMOS (LEVEL $=3 \mathrm{VTO}=1.3 \mathrm{RS}=0.3 \mathrm{RD}=0.3$
$+\mathrm{TOX}=8.5 \mathrm{E}-8 \mathrm{LD}=1.48 \mathrm{E}-6 \mathrm{WD}=1 \mathrm{E}-6 \mathrm{NSUB}=1.53 \mathrm{E} 16 \mathrm{UO}=650 \mathrm{DELTA}=10$
$\operatorname{VMAX}=2 \mathrm{E} 5$

# Dual Low Bias Current Precision Operational Amplifier 

 OP297
## FEATURES

- Precision Performance in Standard SO-8 Pinout
- Low Offset Voltage $\qquad$ $50 \mu \mathrm{~V}$ Max
- Low Offset Voltage Drift $0.6 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ Max
- Very Low Bias Current
$\qquad$
$-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ $\qquad$ 450pA Max
- Very High Open-Loop Gain 2000V/mV Min
- Low Supply Current (Per Amplifier) $625 \mu \mathrm{~A}$ Max
- Operates From $\pm 2 \mathrm{~V}$ to $\pm 20 \mathrm{~V}$ Supplies
- High Common-Mode Rejection $\qquad$ 120dB Min
- Pin Compatible to LT1013, AD706, AD708, OP-221, LM158, and MC1458/1558 with Improved Performance


## APPLICATIONS

- Strain Guage and Bridge Amplifiers
- High Stability Thermocouple Amplifiers
- Instrumentation Amplifiers
- Photo-Current Monitors
- High-Gain Linearity Amplifiers
- Long-Term Integrators/Filters
- Sample-and-Hold Amplifiers
- Peak Detectors
- Logarithmic Amplifiers
- Battery-Powered Systems


## GENERAL DESCRIPTION

The OP-297 is the first dual op amp to pack precision performance into the space-saving, industry standard 8-pin SO package. Its combination of precision with low power and extremely low input bias current makes the dual OP-297 useful in a wide variety of applications.

## LOW BIAS CURRENT OVER TEMPERATURE



Precision performance of the OP-297 includes very low offset, under $50 \mu \mathrm{~V}$, and low drift, below $0.6 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$. Open-loop gain exceeds $2000 \mathrm{~V} / \mathrm{mV}$ insuring high linearity in every application. Errors due to common-mode signals are eliminated by the OP-297's common-mode rejection of over 120dB. The OP-297's power supply rejection of over 120 dB minimizes offset voltage changes experienced in battery powered systems. Supply current of the OP-297 is under $625 \mu \mathrm{~A}$ per amplifier and it can operate with supply voltages as low as $\pm 2 \mathrm{~V}$.

Continued

## PIN CONNECTIONS



## VERY LOW OFFSET



[^200]
## GENERAL DESCRIPTION Continued

The OP-297 utilizes a super-beta input stage with bias current cancellation to maintain picoampbias currents at alltemperatures. This is in contrast to FET input op amps whose bias currents start in the picoamp range at $25^{\circ} \mathrm{C}$, but double for every $10^{\circ} \mathrm{C}$ rise in temperature, to reach the nanoamp range above $85^{\circ} \mathrm{C}$. Input bias current of the OP-297 is under 100 pA at $25^{\circ} \mathrm{C}$ and is under 450 pA over the military temperature range.
Combining precision, low power and low bias current, the OP297 is ideal for a number of applications including instrumentation amplifiers, log amplifiers, photo-diode preamplifiers and longterm integrators. For a single device, see the OP-97; for a quad, see the OP-497.

ORDERING INFORMATION ${ }^{\dagger}$

| $\begin{gathered} \mathrm{T}_{A}=+25^{\circ} \mathrm{C} \\ \mathrm{~V}_{\text {OS }} \text { MAX } \\ (\mu \mathrm{V}) \end{gathered}$ | PACKAGE |  |  | OPERATING TEMPERATURE RANGE |
| :---: | :---: | :---: | :---: | :---: |
|  | CERDIP <br> B-PIN | $\begin{aligned} & \text { PLASTIC } \\ & \text { 8-PIN } \end{aligned}$ | $\begin{gathered} \text { LCC } \\ 20-\text { CONTACT } \end{gathered}$ |  |
| 50 | OP297AZ $883^{*}$ | - | OP297ARC/883* | MIL |
| 50 | OP297AZ | - | - | MIL |
| 50 | OP297EZ | - | - | MIL |
| 100 | OP297FZ | OP297FP | - | XIND |
| 200 | - | OP297GP | - | XIND |
| 200 | - | OP297GS ${ }^{\text {+ }}$ | - | XIND |

- For devices processed in total compliance to MIL-STD-883, add $/ 883$ after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on extended industrial temperature range parts in CerDIP, and plastic DIP packages. For ordering information, see PMI's Data Book, Section 2.
tt For availability and burn-in information on SO packages, contact your local sales office.

| ABSOLUTE MAXIMUM RATINGS (Note 1) |  |  |  |
| :---: | :---: | :---: | :---: |
| Supply Voltage |  |  |  |
| Input Voltage (Note 2) |  |  |  |
| Differential Input Voltage (Note 2) |  |  |  |
| Output Short-Circuit Duration ................................ Indefinite |  |  |  |
| Storage Temperature Range |  |  |  |
| Z, RC-Package ........................................ $-65^{\circ} \mathrm{C}$ to $+175^{\circ} \mathrm{C}$ |  |  |  |
| P, S-Package ............................................ $65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$ |  |  |  |
| Operating Temperature Range |  |  |  |
| OP-297A (Z, RC) ...................................... $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  |  |  |
| OP-297E, F (Z) ......................................... -40 ${ }^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  |  |
| OP-297F, G (P, S) ..................................... $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  |  |
| Junction Temperature |  |  |  |
| Z, RC-Package ....................................... $-65^{\circ} \mathrm{C}$ to $+175^{\circ} \mathrm{C}$ |  |  |  |
| P, S-Package .......................................... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |  |  |  |
| Lead Temperature Range (Soldering, 60 sec ) .............. $300^{\circ} \mathrm{C}$ |  |  |  |
| PACKAGE TYPE | $\Theta_{j A}$ (Note 3) | $\theta_{j} \mathrm{c}$ | UNITS |
| 8 -Pin CerDIP (Z) | 134 | 12 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8 -Pin Plastic DIP (P) | 96 | 37 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 20-Contact LCC (RC) | 88 | 33 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8 -Pin SO (S) | 150 | 41 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

NOTES:

1. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
2. For supply voltages less than $\pm 20 \mathrm{~V}$, the absolute maximum input voltage is equal to the supply voltage.
3. $\Theta_{j A}$ is specified for worst case mounting conditions, i.e., $\Theta_{j A}$ is specified for device in socket for CerDIP, P-DIP, and LCC packages; $\Theta_{j A}$ is specified for device soldered to printed circuit board for SO package.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-297A/E |  |  | OP-297F |  |  | OP-297G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Input Offset Voltage | $V_{\text {OS }}$ |  | - | 25 | 50 | - | 50 | 100 | - | 80 | 200 | $\mu \mathrm{V}$ |
| Long-Term Input Voltage Stability |  |  | - | 0.1 | - | - | 0.1 | - | - | 0.1 | - | $\mu \mathrm{V} / \mathrm{mo}$ |
| Input Offset Current | los | $\mathrm{V}_{\mathrm{CM}}=\mathrm{OV}$ | - | 20 | 100 | - | 35 | 150 | - | 50 | 200 | pA |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ | $\mathrm{V}_{\mathrm{CM}}=\mathrm{OV}$ | - | 20 | $\pm 100$ | - | 35 | $\pm 150$ | - | 50 | $\pm 200$ | pA |
| Input Noise Voltage | $e_{n p-p}$ | 0.1 Hz to 10 Hz | - | 0.5 | - | - | 0.5 | - | - | 0.5 | - | $\mu V_{p-p}$ |
| Input Noise Voltage Density | $e_{n}$ | $\begin{aligned} & \mathrm{f}_{\mathrm{O}}=10 \mathrm{~Hz} \\ & \mathrm{f}_{\mathrm{O}}=1000 \mathrm{~Hz} \end{aligned}$ | - | $\begin{aligned} & 20 \\ & 17 \end{aligned}$ | - | - | $\begin{aligned} & 20 \\ & 17 \end{aligned}$ | - | - | $\begin{aligned} & 20 \\ & 17 \end{aligned}$ | - | $n \mathrm{VV} \sqrt{\mathrm{Hz}}$ |
| Input Noise Current Density | $i_{n}$ | $\mathrm{f}_{\mathrm{O}}=10 \mathrm{~Hz}$ | - | 20 | - | - | 20 | - | - | 20 | - | $\mathrm{f} \mathrm{A} \sqrt{\mathrm{Hz}}$ |
| Input Resistance Differential Mode | $\mathrm{R}_{\text {IN }}$ |  | - | 30 | - | - | 30 | - | - | 30 | - | M $\Omega$ |
| Input Resistance Common-Mode | $\mathrm{R}_{\text {INCM }}$ |  | - | 500 | - | - | 500 | - | - | 500 | - | G $\Omega$ |
| Large-Signal Voltage Gain | Avo | $\begin{aligned} & V_{\mathrm{O}}= \pm 10 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \end{aligned}$ | 2000 | 4000 | - | 1500 | 3200 | - | 1200 | 3200 | - | V/mV |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted. Continued

| PARAMETER | SYMBOL | CONDITIONS | OP-297A/E |  |  | OP-297F |  |  | OP-297G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Input Voltage Range | IVR | (Note 1) | $\pm 13$ | $\pm 14$ | - | $\pm 13$ | $\pm 14$ | - | $\pm 13$ | $\pm 14$ | - | V |
| Common-Mode Rejection | CMR | $V_{C M}= \pm 13 \mathrm{~V}$ | 120 | 140 | - | 114 | 135 | - | 114 | 135 | - | dB |
| Power Supply Rejection | PSR | $\mathrm{V}_{\mathrm{S}}= \pm 2 \mathrm{~V}$ to $\pm 20 \mathrm{~V}$ | 120 | 130 | - | 114 | 125 | - | 114 | 125 | - | dB |
| Output Voltage Swing | $v_{0}$ | $\begin{aligned} & R_{\mathrm{L}}=10 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \end{aligned}$ | $\begin{aligned} & \pm 13 \\ & \pm 13 \end{aligned}$ | $\begin{array}{r}  \pm 14 \\ \pm 13.7 \end{array}$ | - | $\begin{aligned} & \pm 13 \\ & \pm 13 \end{aligned}$ | $\begin{array}{r}  \pm 14 \\ \pm 13.7 \end{array}$ | - | $\begin{aligned} & \pm 13 \\ & \pm 13 \end{aligned}$ | $\begin{array}{r}  \pm 14 \\ \pm 13.7 \end{array}$ | - | V |
| Supply Current Per Amplifier | $\mathrm{I}_{\mathbf{S Y}}$ | No Load | - | 525 | 625 | - | 525 | 625 | - | 525 | 625 | $\mu \mathrm{A}$ |
| Supply Voltage | $\mathrm{v}_{\mathrm{s}}$ | Operating Range | $\pm 2$ | - | +20 | $\pm 2$ | - | $\pm 20$ | $\pm 2$ | - | $\pm 20$ | V |
| Slew Rate | SR |  | 0.05 | 0.15 | - | 0.05 | 0.15 | - | 0.05 | 0.15 | - | $\mathrm{V} / \mathrm{\mu s}$ |
| Gain Bandwith Product | GBWP | $A_{V}=+1$ | - | 500 | - | - | 500 | - | - | 500 | - | kHz |
| Channel Separation | CS | $\begin{aligned} & V_{\mathrm{O}}=20 \mathrm{~V}_{\mathrm{p}-\mathrm{p}} \\ & \mathrm{f}_{\mathrm{O}}=10 \mathrm{Zz} \end{aligned}$ | - | 150 | - | - | 150 | - | - | 150 | - | dB |
| Input Capacitance | $\mathrm{Cin}_{\text {IN }}$ |  | - | 3 | - | - | 3 | - | - | 3 | - | pF |

NOTE:

1. Guaranteed by CMR test.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V},-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ for OP-297A, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-297A |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX |  |
| Input Offset Voltage | Vos |  | - | 45 | 100 | $\mu \mathrm{V}$ |
| Average input Offset Voltage Drift | TCV ${ }_{\text {os }}$ |  | - | 0.2 | 0.6 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current | los | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 60 | 450 | pA |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ | $\mathrm{V}_{\mathrm{CM}}=\mathrm{OV}$ | - | 60 | $\pm 450$ | pA |
| Large-Signal Voltage Gain | Avo | $\mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | 1200 | 2700 | - | V/mV |
| Input Voltage Range | IVR | (Note 1) | $\pm 13$ | $\pm 13.5$ | - | V |
| Common-Mode Rejection | CMR | $\mathrm{V}_{\mathrm{CM}}= \pm 13$ | 114 | 130 | - | dB |
| Power Supply Rejection | PSR | $\mathrm{V}_{\mathrm{S}}= \pm 2.5 \mathrm{~V}$ to $\pm 20 \mathrm{~V}$ | 114 | 125 | - | dB |
| Output Voltage Swing | $v_{0}$ | $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ | $\pm 13$ | $\pm 13.4$ | - | V |
| Supply Current Per Amplifier | Isy | No Load | - | 575 | 750 | $\mu \mathrm{A}$ |
| Supply Voltage | $\mathrm{v}_{\mathrm{s}}$ | Operating Range | $\pm 2.5$ | - | $\pm 20$ | V |

## NOTE:

1. Guaranteed by CMR test.

ELECTRICAL CHARACTERISTICS at $V_{S}= \pm 15 \mathrm{~V},-40^{\circ} \mathrm{C} \leq T_{A} \leq+85^{\circ} \mathrm{C}$ for OP-297E/F/G, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-297E |  |  | OP-297F |  |  | OP-297G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Input Offset Voltage | $V_{\text {os }}$ |  | - | 35 | 100 | - | 80 | 300 | - | 110 | 400 | $\mu \mathrm{V}$ |
| Average Input Offset Voltage Drift | TCVos |  | - | 0.2 | 0.6 | - | 0.5 | 2.0 | - | 0.6 | 2.0 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current | los | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 50 | 450 | - | 80 | 750 | - | 80 | 750 | pA |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ | $V_{C M}=0 \mathrm{~V}$ | - | 50 | $\pm 450$ | - | 80 | $\pm 750$ | - | 80 | $\pm 750$ | pA |
| Large-Signal Voltage Gain | Avo | $V_{O}= \pm 10 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | 1200 | 3200 | - | 1000 | 2500 | - | 800 | 2500 | - | $\mathrm{V} / \mathrm{mV}$ |
| Input Voltage Range | IVR | (Note 1) | $\pm 13$ | $\pm 13.5$ | - | $\pm 13$ | $\pm 13.5$ | - | $\pm 13$ | $\pm 13.5$ | - | V |
| Common-Mode Rejection | CMR | $V_{C M}= \pm 13 V$ | 114 | 130 | - | 108 | 130 | - | 108 | 130 | - | dB |
| Power Supply Rejection | PSR | $V_{S}= \pm 2.5 \mathrm{~V}$ to $\pm 20 \mathrm{~V}$ | 114 | 0.15 | - | 108 | 0.15 | - | 108 | 0.3 | - | dB |
| Output Voltage Swing | $V_{0}$ | $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ | $\pm 13$ | $\pm 13.4$ | - | $\pm 13$ | $\pm 13.4$ | - | $\pm 13$ | $\pm 13.4$ | - | V |
| Supply Current Per Amplifier | Isy | No Load | - | 550 | 750 | - | 550 | 750 | - | 550 | 750 | $\mu \mathrm{A}$ |
| Supply Voltage | $v_{s}$ | Operating Range | $\pm 2.5$ | - | $\pm 20$ | $\pm 2.5$ | - | $\pm 20$ | $\pm 2.5$ | - | $\pm 20$ | V |

## NOTE:

1. Guaranteed by CMR test.

## CHANNEL SEPARATION TEST CIRCUIT



## FEATURES

- Low Input Offset Voltage
- Low Offset Voltage Drift, Over $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ $\qquad$ $1.2 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ Max
- Low Supply Current (Per Amplifier) $.725 \mu \mathrm{~A}$ Max
- High Open-Loop Gain .................................5000V/mV Min
- Input Bias Current $\qquad$ 3nA Max
- Low Noise Voltage Density ................ $11 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ at 1 kHz
- Stable With Large Capacitive Loads. $\qquad$ 10nF Typ
- Pin Compatible to OP-11, LM148, HA4741, RM4156, and LT1014 With Improved Performance
- Available in Die Form

ORDERING INFORMATION ${ }^{\dagger}$

| $\begin{gathered} \mathrm{T}_{A}=+25^{\circ} \mathrm{C} \\ \mathrm{~V}_{\mathrm{OS}} \mathrm{MAX} \\ (\mathrm{mV}) \\ \hline \end{gathered}$ | PACKAGE |  |  | OPERATING TEMPERATURE RANGE |
| :---: | :---: | :---: | :---: | :---: |
|  | $\begin{aligned} & \text { CERDIP } \\ & \text { 14-PIN } \end{aligned}$ | PLASTIC | $\frac{\text { LCC }}{28-C O N T A C T}$ |  |
| 150 | OP400AY* | - | OP400ATC/883 | MIL |
| 150 | OP400EY | - | - | IND |
| 230 | OP400FY | - | - | IND |
| 300 | - | OP400GP | - | COM |
| 300 | - | OP400GS ${ }^{\text {H }}$ | - | COM |
| 300 | - | OP400HP | - | XIND |
| 300 | - | OP400HS ${ }^{\text {H }}$ | - | XIND |

* For devices processed in total compliance to MIL-STD-883, add/883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.
t $\dagger$ For availablity and burn-in information on SO and PLCC packages, contact your local sales office.


## GENERAL DESCRIPTION

The OP-400 is the first monolithic quad operational amplifier that features OP-77 type performance. Precision performance no longer has to be sacrificed to obtain the space and cost savings offered by quad amplifiers.
The OP-400 features an extremely low input offset voltage of less than $150 \mu \mathrm{~V}$ with a drift of under $1.2 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$, guaranteed

## PIN CONNECTIONS



SIMPLIFIED SCHEMATIC (One of four amplifiers is shown.)


This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.
over the full military temperature range. Open-loop gain of the OP-400 is over $5,000,000$ into a $10 \mathrm{k} \Omega$ load; input bias current is under 3 nA ; CMR is above 120 dB and PSRR below $1.8 \mu \mathrm{~V} / \mathrm{V}$. On-chip zener-zap trimming is used to achieve the low input offset voltage of the OP-400 and eliminates the need for offset nulling. (The OP-400 conforms to the in-dustry-standard quad pinout which does not have null terminals.)
The OP-400 features low power consumption, drawing less than $725 \mu \mathrm{~A}$ per amplifier. The total current drawn by this quad amplifier is less than that of a single OP-07, yet the OP-400 offers significant improvements over this industrystandard op amp. Voltage noise density of the OP-400 is a low $11 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ at 10 Hz which is half that of most competitive devices.

The OP-400 is pin compatible with the OP-11, LM148, HA4741, RM4156, and LT1014 operational amplifiers and can be used to upgrade systems using these devices. The OP-400 is an ideal choice for applications requiring multiple precision operational amplifiers and where low power consumption is critical.

ABSOLUTE MAXIMUM RATINGS (Note 2)
Supply Voltage
$\pm 20 \mathrm{~V}$
Differential Input Voltage .................................................. $\pm 30 \mathrm{~V}$
Input Voltage .................................................... Supply Voltage
Output Short-Circuit Duration ................................ Continuous
Storage Temperature Range
P, TC, Y-Package $\qquad$ $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

| Lead Temperature Range (Soldering 60 sec ) $\qquad$ $300^{\circ} \mathrm{C}$ Junction Temperature ( $\mathrm{T}_{1}$ ) $\qquad$ $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |  |  |  |
| :---: | :---: | :---: | :---: |
| Operating Temperature Range |  |  |  |
| OP-400A ............................................... $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  |  |  |
| OP-400E, OP-400F ................................. -25 ${ }^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  |  |
| OP-400G .................................................... $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ |  |  |  |
| OP-400H ............................................... $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  |  |
| PACKAGE TYPE | $\theta_{\text {IA }}$ (Note 1) | $\theta_{\text {Ic }}$ | UNITS |
| 14-Pin Hermetic DIP $(Y)$ | 94 | 10 | ${ }^{\circ} \mathrm{C} / \mathrm{N}$ |
| 14-Pin Plastic DIP (P) | 76 | 33 | ${ }^{\circ} \mathrm{CN}$ |
| 28-Contact LCC (TC) | 70 | 28 | ${ }^{\circ} \mathrm{C}$ W |
| 16-Pin SOL (S) | 88 | 23 | ${ }^{\circ} \mathrm{C}$ |

## NOTES:

1. $\Theta_{j \Lambda}$ is specified for worst case mounting conditions, i.e., $\Theta_{j \Lambda}$ is specified for device in socket for TO, CerDIP, P-DIP, and LCC packages; $\Theta_{i A}$ is specified for device soldered to printed circuit board for SO package.
2. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.

|  |  |  | OP-400A/E |  |  | OP-400F |  |  | OP-400G/H |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Input Offset Voltage | $\mathrm{V}_{\text {OS }}$ |  | - | 40 | 150 | - | 60 | 230 | - | 80 | 300 | $\mu \mathrm{V}$ |
| Long Term Input Voltage Stability |  |  | - | 0.1 | - | - | 0.1 | - | - | 0.1 | - | $\mu \mathrm{V} / \mathrm{mo}$ |
| Input Offset Current | los | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 0.1 | 1.0 | - | 0.1 | 2.0 | - | 0.1 | 3.5 | $n A$ |
| Input Bias Current | $I_{B}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 0.75 | 3.0 | - | 0.75 | 6.0 | - | 0.75 | 7.0 | $n A$ |
| Input Noise Voltage | $e_{n p-p}$ | 0.1 Hz to 10 Hz | - | 0.5 | - | - | 0.5 | - | - | 0.5 | - | $\mu V_{p-p}$ |
| Input Noise Voltage Density | $e_{n}$ | $\left.\begin{array}{l} \mathrm{f}_{\mathrm{O}}=10 \mathrm{~Hz} \\ \mathrm{f}_{\mathrm{O}}=1000 \mathrm{~Hz} \end{array} \text { (Note } 1\right)$ | - | $\begin{array}{r} 22 \\ 11 \end{array}$ | $\begin{aligned} & 36 \\ & 18 \end{aligned}$ | - | $\begin{aligned} & 22 \\ & 11 \end{aligned}$ | $\begin{aligned} & 36 \\ & 18 \end{aligned}$ | - | $\begin{aligned} & 22 \\ & 11 \end{aligned}$ | - | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| Input Noise Current | $i_{n p-p}$ | 0.1 Hz to 10 Hz | - | 15 | - | - | 15 | - | - | 15 | - | $p A_{p-p}$ |
| Input Noise Current Density | $i_{n}$ | $\mathrm{f}_{\mathrm{O}}=10 \mathrm{~Hz}$ | - | 0.6 | - | - | 0.6 | - | - | 0.6 | - | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
| Input Resistance Differential Mode | $\mathrm{R}_{\text {IN }}$ |  | - | 10 | - | - | 10 | - | - | 10 | - | $\mathrm{M} \Omega$ |
| Input Resistance Common Mode | $\mathrm{R}_{\text {INCM }}$ |  | - | 200 | - | - | 200 | - | - | 200 | - | $\mathrm{G} \Omega$ |
| Large Signal Voltage Gain | Avo | $\begin{aligned} & \mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & \hline \end{aligned}$ | $\begin{aligned} & 5000 \\ & 2000 \end{aligned}$ | $\begin{array}{r} 12000 \\ 3500 \end{array}$ | - | $\begin{array}{r}3000 \\ 1500 \\ \hline\end{array}$ | $\begin{aligned} & 7000 \\ & 3000 \end{aligned}$ | - | $\begin{aligned} & 3000 \\ & 1500 \end{aligned}$ | $\begin{aligned} & 7000 \\ & 3000 \end{aligned}$ | - | V/mV |

OP400
ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted. (Continued)

| PARAMETER | SYMBOL | CONDITIONS | OP-400A/E |  |  | OP-400F |  |  | OP-400G/H |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Input Voltage Range | IVR | Note 3 | $\pm 12$ | $\pm 13$ | - | $\pm 12$ | $\pm 13$ | - | $\pm 12$ | $\pm 13$ | - | V |
| Common Mode Rejection | CMR | $\mathrm{V}_{\mathrm{CM}}= \pm 12 \mathrm{~V}$ | 120 | 140 | - | 115 | 140 | - | 110 | 135 | - | dB |
| Power Supply Rejection Ratio | PSRR | $\mathrm{V}_{S}= \pm 3 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | 0.1 | 1.8 | - | 0.1 | 3.2 | - | 0.2 | 5.6 | $\mu \mathrm{V} / \mathrm{V}$ |
| Output Voltage Swing | $V_{0}$ | $\begin{aligned} & R_{\mathrm{L}}=10 \mathrm{k} \Omega \\ & R_{\mathrm{L}}=2 \mathrm{k} \Omega \end{aligned}$ | $\begin{aligned} & \pm 12 \\ & \pm 11 \end{aligned}$ | $\begin{gathered} \pm 12.6 \\ \pm 12.2 \end{gathered}$ | - | $\begin{aligned} & \pm 12 \\ & \pm 11 \end{aligned}$ | $\begin{aligned} & \pm 12.6 \\ & \pm 12.2 \end{aligned}$ | - | $\begin{aligned} & \pm 12 \\ & \pm 11 \end{aligned}$ | $\begin{aligned} & \pm 12.6 \\ & \pm 12.2 \end{aligned}$ | - | V |
| Supply Current Per Amplifier | $\mathrm{I}_{\mathrm{SY}}$ | No Load | - | 600 | 725 | - | 600 | 725 | - | 600 | 725 | $\mu \mathrm{A}$ |
| Slew Rate | SR |  | 0.1 | 0.15 | - | 0.1 | 0.15 | - | 0.1 | 0.15 | - | $\mathrm{V} / \mu \mathrm{s}$ |
| Gain Bandwidth Product | GBWP | $A_{V}=+1$ | - | 500 | - | - | 500 | - | - | 500 | - | kHz |
| Channel Separation | CS | $\begin{aligned} & \mathrm{V}_{\mathrm{O}}=20 \mathrm{~V}_{\mathrm{p}-\mathrm{p}} \\ & \mathrm{f}_{\mathrm{O}}=10 \mathrm{~Hz} \text { (Note 2) } \end{aligned}$ | 123 | 135 | - | 123 | 135 | - | 123 | 135 | - | dB |
| Input Capacitance | $\mathrm{CIN}_{\text {IN }}$ |  | - | 3.2 | - | - | 3.2 | - | - | 3.2 | - | pF |
| Capacitive Load Stability |  | $A_{\mathbf{V}}=+1$ <br> No Oscillations | - | 10 | - | - | 10 | - | - | 10 | - | nF |

NOTES:

1. Sample tested.
2. Guaranteed but not $100 \%$ tested.
3. Guaranteed by CMR test.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V},-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq 125^{\circ} \mathrm{C}$ for $\mathrm{OP}-400 \mathrm{~A}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-400A |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX |  |
| Input Offset Voltage | $\mathrm{V}_{\text {OS }}$ |  | - | 70 | 270 | $\mu \mathrm{V}$ |
| Average Input Offset Voltage Drift | $\mathrm{TCV}_{\text {Os }}$ |  | - | 0.3 | 1.2 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current | Ios | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 0.1 | 2.5 | nA |
| Input Bias Current | $\mathrm{I}_{B}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 1.3 | 5.0 | nA |
| Large Signal Voltage Gain | $A_{\text {vo }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & \hline \end{aligned}$ | $\begin{aligned} & 3000 \\ & 1000 \end{aligned}$ | $\begin{aligned} & 9000 \\ & 2300 \end{aligned}$ | - | $\mathrm{V} / \mathrm{mV}$ |
| Input Voltage Range | IVR | Note 1 | $\pm 12$ | $\pm 12.5$ | - | V |
| Common Mode Rejection | CMR | $\mathrm{V}_{\mathrm{CM}}= \pm 12 \mathrm{~V}$ | 115 | 130 | - | dB |
| Power Supply Rejection Ratio | PSRR | $V_{S}= \pm 3 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | 0.2 | 3.2 | $\mu \mathrm{V} / \mathrm{V}$ |
| Output Voltage Swing | $\mathrm{V}_{0}$ | $\begin{aligned} & R_{\mathrm{L}}=10 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \end{aligned}$ | $\begin{aligned} & \pm 12 \\ & \pm 11 \end{aligned}$ | $\begin{array}{r}  \pm 12.4 \\ \pm 12 \end{array}$ | - | V |
| Supply Current Per Amplifier | $\mathrm{I}_{\text {SY }}$ | No Load | - | 600 | 775 | $\mu \mathrm{A}$ |
| Capacitive Load Stability |  | $A_{\mathbf{V}}=+1$ <br> No Oscillations | - | 8 | - | nF |

## NOTE:

1. Guaranteed by CMR test.

ELECTRICAL CHARACTERISTICS at $V_{S}= \pm 15 \mathrm{~V},-25^{\circ} \mathrm{C} \leq T_{A} \leq \pm 85^{\circ} \mathrm{C}$ for OP-400E/F, $0^{\circ} \mathrm{C} \leq T_{A} \leq+70^{\circ} \mathrm{C}$ for $\mathrm{OP}-400 \mathrm{G},-40^{\circ} \mathrm{C}$ $\leq T_{A} \leq+85^{\circ} \mathrm{C}$ for OP-400H, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-400E |  |  | OP-400F |  |  | OP-400G/H |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | max | MIN | TYP | MAX | MIN | TYP | Max |  |
| Input Offset Voltage | $V_{\text {os }}$ |  | - | 60 | 220 | - | 80 | 350 | - | 110 | 400 | $\mu \mathrm{V}$ |
| Average input Offset Voltage Drift | $\mathrm{TCV}_{\text {os }}$ |  | - | 0.3 | 1.2 | - | 0.3 | 2.0 | - | 0.6 | 2.5 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current | los | $\begin{aligned} & \mathrm{V}_{\mathrm{CM}}=\mathrm{OV} \\ & E, \mathrm{~F}_{1} \mathrm{G} \text { Grades } \\ & \mathrm{H} \text { Grade } \end{aligned}$ | - | 0.1 | 2.5 | - | 0.1 | 3.5 | - | $\begin{aligned} & 0.2 \\ & 0.2 \end{aligned}$ | $\begin{array}{r} 6.0 \\ 12.0 \end{array}$ | nA |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ | $\begin{aligned} & V_{C M M}=O V \\ & E, F, G \text { Grades } \\ & \text { H Grade } \end{aligned}$ |  | 0.9 - | 5.0 | - | 0.9 | 10.0 | - | $\begin{aligned} & 1.0 \\ & 1.0 \end{aligned}$ | $\begin{aligned} & 12.0 \\ & 20.0 \end{aligned}$ | nA |
| Large-Signal Voltage Gain | $A_{\text {vo }}$ | $\begin{aligned} & V_{O}= \pm 10 \mathrm{~V} \\ & R_{L}=10 \mathrm{k} \Omega \\ & R_{L}=2 \mathrm{k} \Omega \\ & \hline \end{aligned}$ |  | $\begin{array}{r} 10000 \\ 2700 \end{array}$ |  | $\begin{aligned} & 2000 \\ & 1000 \end{aligned}$ | $\begin{aligned} & 5000 \\ & 2000 \end{aligned}$ | - | $\begin{aligned} & 2000 \\ & 1000 \end{aligned}$ | $\begin{aligned} & 5000 \\ & 2000 \end{aligned}$ | - | V/mV |
| Input Voltage Range | IVR | (Note 1) | $\pm 12$ | $\pm 12.5$ | - | $\pm 12$ | $\pm 12.5$ | - | $\pm 12$ | $\pm 12.5$ | - | V |
| Common-Mode Rejection | CMR | $V_{C M}= \pm 12 \mathrm{~V}$ | 115 | 135 | - | 110 | 135 | - | 105 | 130 | - | dB |
| Power Supply Rejection Ratio | PSRR | $V_{S}= \pm 3 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | 0.15 | 3.2 | - | 0.15 | 5.6 | - | 0.3 | 10.0 | $\mu \mathrm{V} / \mathrm{V}$ |
| Output Voltage Swing | $v_{0}$ | $\begin{aligned} & R_{L}=10 \mathrm{k} \Omega \\ & R_{L}=2 \mathrm{k} \Omega \end{aligned}$ | $\begin{aligned} & \pm 12 \\ & \pm 11 \end{aligned}$ | $\begin{array}{r}  \pm 12.4 \\ \pm 12 \end{array}$ | - | $\begin{aligned} & \pm 12 \\ & \pm 11 \end{aligned}$ | $\begin{array}{r}  \pm 12.4 \\ \pm 12 \end{array}$ | - | $\begin{aligned} & \pm 12 \\ & \pm 11 \end{aligned}$ | $\begin{aligned} & \pm 12.6 \\ & \pm 12.2 \end{aligned}$ | - | v |
| Supply Current Per Amplifier | $\mathrm{I}_{\mathbf{S Y}}$ | No Load | - | 600 | 775 | - | 600 | 775 | - | 600 | 775 | $\mu \mathrm{A}$ |
| Capacitive Load Stability |  | $A_{v}=+1$ <br> No Oscillations | - | 10 | - | - | 10 | - | - | 10 | - | nF |

## NOTE:

1. Guaranteed by CMR test.

## FEATURES

- Low Supply Current . . . . . . . . . . . 200 $\mu \mathrm{A}$ Max @ $\mathbf{V}_{\mathbf{S}}=+5 \mathrm{~V}$
- Single-Supply Operation .................... +5 F to +30 V
- Dual-Supply Operation .................. . . $\pm 2.5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$
- Low Input Offset Voltage ...................... $500 \mu$ V Typ
- Low Input Offset Voltage Drift .............. $5 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}^{\circ}$ Typ
- High Common-Mode Input Range ... V-to (V+-1.5V)
- High CMRR ...................................... 100dB Typ
- High Open-Loop Gain . . . . . . . . . . . . . . . . . . 1100V/mV Typ
- LM 148 Pinout
- Available in Die Form


## ORDERING INFORMATION ${ }^{\dagger}$

| $\begin{gathered} T_{A}=+25^{\circ} \mathrm{C} \\ \mathbf{V}_{\substack{\text { OSAX } \\ (\mathrm{mV})}} \end{gathered}$ | PACKAGE |  |  | operating TEMPERATURE RANGE |
| :---: | :---: | :---: | :---: | :---: |
|  | CERDIP <br> 14-PIN | $\begin{gathered} \text { LCC } \\ \text { 20-CONTACT } \end{gathered}$ | PLASTIC |  |
| 2.5 | OP420BY | - | - | MIL |
| 2.5 | OP420FY | - | - | IND |
| 4.0 | OP420CY | OP420CRC/883 | - | MIL. |
| 4.0 | OP420GY | - | OP420GP | XIND |
| 4.0 | - | - | OP420GS | XIND |
| 6.0 | OP420HY | - | OP420HP | XIND |
| 6.0 | - | - | OP420HS | XIND |

- For devices processed in total compliance to MIL-STD-883, add /883 after part number. Consult factory for $\mathbf{8 8 3}$ data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.


## GENERAL DESCRIPTION

The OP-420 quad micropower operational amplifier is a single-chip quad patterned after the OP-20 precision micropower single operational amplifier. A Darlington PNP input stage allows the input common-mode voltage to include V -. The wide input range combined with low power-supply drain

## PIN CONNECTIONS



14-PIN HERMETIC DIP (Y-Suffix)
14-PIN EPOXY DIP (P-Suffix) OP-420CRC/883
20-LEAD LCC
(RC-Suffix)


16-PIN SOL (S-Suffix)

( $\sim 40 \mu \mathrm{~A} /$ section at 5 V ), provides a unique solution for designs requiring high functional density and portable operation. Applications include two-wire transmitters for process control loops, battery-operated remote-line filters, signal preconditioning amplifiers, and a variety of multiple-gain block arrays.
For micropower applications requiring offset nulling, see the OP-20, OP-21 and OP-22 data sheets.

## SIMPLIFIED SCHEMATIC (1/4 Shown)



[^201] complete data sheet, call our fax retrieval system at 1-800-446-6212.

ABSOLUTE MAXIMUM RATINGS (Note 1)
Supply Voltage .................................................................. $\pm 18 \mathrm{~V}$
Differential Input Voltage ................................................... $\pm 30 \mathrm{~V}$
Input Voltage .................................................... Supply Voltage
Output Short-Circuit Duration ................................ Continuous (One Amplifier Only)
Storage Temperature Range ......................... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature Range (Soldering, 60 sec )
............. $.300^{\circ} \mathrm{C}$
Operating Temperature Range
OP-420BY, OP-420CY, OP-420CRC ......... $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
OP-420FY ..................................................... $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
OP-420G, OP-420H...................................... $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Junction Temperature( $\mathrm{T}_{\mathrm{f}}$ ) .............................. $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

| PACKAGE TYPE | $\boldsymbol{\theta}_{1 \mathrm{~A}}$ (Note 2) | $\theta_{\text {IC }}$ | UNITS |
| :---: | :---: | :---: | :---: |
| 14-Pin Hermetic DIP (Y) | 99 | 12 | ${ }^{\circ} \mathrm{C}$ W |
| 14-Pin Plastic DIP (P) | 76 | 33 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $16-\mathrm{Pin} \mathrm{SOL}$ (S) | 92 | 27 | ${ }^{\circ} \mathrm{CNW}$ |

## NOTES

1. Absolute maximum ratings apply to both DICE and packaged parts, uniess otherwise noted.
2. $\Theta_{j A}$ is specified for worst case mounting conditions, i.e., $\Theta_{j A}$ is specified for device in socket for CerDIP and P-DIP packages; $\Theta_{j A}$ is specified for device soldered to printed circuit board for SOL package.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.


## NOTE:

1. $I_{B}$ and $I_{O S}$ are measured at $V_{C M}=0$.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V},-55^{\circ} \mathrm{C} \leq+125^{\circ} \mathrm{C}$ for OP-420B and OP-420C, $-25^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ for OP $420 \mathrm{~F},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ for $\mathrm{OP}-420 \mathrm{G}$ and $\mathrm{OP}-420 \mathrm{H}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | $\begin{aligned} & \text { OP-420B } \\ & \text { OP-420F } \end{aligned}$ |  |  | $\begin{aligned} & \text { OP-420C } \\ & \text { OP-420G } \end{aligned}$ |  |  | OP-420H |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | max | MIN | TYP | MAX |  |
| Average Input Offset Voltage Drift (Note 1) | $\mathrm{TCV}_{\mathrm{os}}$ | Unnulled | - | 5 | 10 | - | 8 | 15 | - | 15 | 25 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Voltage | $\mathrm{V}_{\mathrm{OS}}$ | $V_{S}= \pm 2.5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$ | - | - | 3.5 | - | - | 5.5 | - | - | 7.5 | mV |
| Input Offset Current (Note 2) | Ios | $V_{S}= \pm 2.5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$ | - | - | 3 | - | - | 4 | - | - | 8 | nA |
| Input Bias Current (Note 2) | $I_{B}$ | $\mathrm{V}_{\mathrm{S}}= \pm 2.5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$ | - | - | 30 | - | - | 40 | - | - | 60 | nA |
| Input Voltage Range | IVR | $\begin{aligned} & \mathrm{V}+=+5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V} \end{aligned}$ | $\begin{array}{r} 0 / 3.2 \\ -15 / 13.2 \\ \hline \end{array}$ | - | - | $\begin{array}{r} 0 / 3.2 \\ -15 / 13.2 \end{array}$ | - | - | $\begin{array}{r} 0 / 3.2 \\ -15 / 13.2 \end{array}$ | - | - | V |
| Common-Mode Rejection Ratio | CMRR | $\begin{aligned} & \mathrm{V}+=+5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V}, \\ & \mathrm{OV} \leq \mathrm{V}_{\mathrm{CM}} \leq 3.2 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \\ & -15 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CM}} \leq 13.2 \mathrm{~V} \end{aligned}$ | 76 76 | 96 96 | - - | 73 73 | 92 92 | - - | 73 73 | 86 86 | - | dB |
| Power Supply Rejection Ratio | PSRR | $\begin{aligned} & V_{S}= \pm 2.5 \mathrm{~V} \text { to } \pm 15 \mathrm{~V} \\ & \text { and } \mathrm{V}-=0 \mathrm{~V}, \mathrm{~V}+=5 \mathrm{~V} \\ & \text { to } 30 \mathrm{~V} \end{aligned}$ | - | 15 | 50 | - | 25 | 80 | - | 40 | 100 | $\mu \mathrm{V} / \mathrm{V}$ |
| Large-Signal Voltage Gain | $A_{\text {vo }}$ | $\begin{aligned} & V_{S}= \pm 15 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \mathrm{k} \Omega \\ & \mathrm{~V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \end{aligned}$ | 300 | 800 | - | 200 | 650 | - | 100 | 400 | - | V/mV |
| Output Voltage Swing | $\mathrm{V}_{0}$ | $\begin{aligned} & \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V}, \\ & R_{\mathrm{L}}=20 \mathrm{k} \Omega \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \\ & \mathrm{R}_{\mathrm{L}}=50 \mathrm{k} \Omega \\ & \hline \end{aligned}$ | $\begin{array}{r} 0.9 / 3.9 \\ \pm 13.8 \end{array}$ | - - | - - | $\begin{aligned} & 1.0 / 3.8 \\ & \pm 13.8 \end{aligned}$ | - | - | $\begin{aligned} & 1.1 / 3.6 \\ & \pm 13.6 \end{aligned}$ | - | - | V |
| Supply Current (Four Amplifiers) | $\mathrm{I}_{\mathbf{S Y}}$ | $\begin{aligned} & V_{S}= \pm 2.5 \mathrm{~V}, \text { No Load } \\ & V_{S}= \pm 15 \mathrm{~V}, \text { No Load } \end{aligned}$ | - | $\begin{array}{r} 170 \\ 390 \\ \hline \end{array}$ | $\begin{array}{r} 300 \\ 500 \\ \hline \end{array}$ | - | 210 420 | $\begin{aligned} & 400 \\ & 640 \end{aligned}$ | - | 250 500 | $\begin{aligned} & 600 \\ & 800 \end{aligned}$ | $\mu \mathrm{A}$ |

## NOTES:

1. Sample tested.
2. $\mathrm{I}_{\mathrm{B}}$ and $\mathrm{I}_{\mathrm{OS}}$ are measured at $\mathrm{V}_{\mathrm{CM}}=0$.

# Quad Precision, High Speed Operational Amplifier 

## FEATURES

High Slew Rate - 170 V/ $\mu \mathrm{s}$
Wide Bandwidth - 28 MHz
Fast Settling Time $-<200$ ns to $\mathbf{0 . 0 1 \%}$
Low Offset Voltage - < 500 $\mu \mathrm{V}$
Unity-Gain Stable
Low Voltage Operation $\pm 5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$
Low Supply Current - <10 mA
Drives Capacitive Loads

## APPLICATIONS

## High Speed Image Display Drivers <br> High Frequency Active Filters <br> Fast Instrumentation Amplifiers <br> High Speed Detectors <br> Integrators <br> Photo Diode Preamps

## GENERAL DESCRIPTION

The OP-467 is a quad, high speed, precision operational amplifier. It offers the performance of a high speed op amp combined with the advantages of a precision operational amplifier all in a single package. The OP-467 is an ideal choice for applications where, traditionally, more than one op amp was used to achieve this level of speed and precision.
The OP-467's internal compensation ensures stable unity-gain operation, and it can drive large capacitive loads without oscillation. With a gain bandwidth product of 28 MHz driving a 30 pF load, output slew rate in excess of $170 \mathrm{~V} / \mu \mathrm{s}$, and settling time to $0.01 \%$ in less than 200 ns , the OP-467 provides excellent dynamic accuracy in high speed data-acquisition systems. The channel-to-channel separation is typically 60 dB at 10 MHz .
The dc performance of OP-467 includes less than 0.5 mV of offset, voltage noise density below $6 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ and total supply current under 10 mA . Common-mode rejection and power supply rejection ratios are typically 85 dB . PSRR is maintained to better than 40 dB with input frequencies as high as 1 MHz . The low offset and drift plus high speed and low noise, make the OP-467 usable in applications such as high speed detectors and instrumentation.
The OP-467 is specified for operation from $\pm 5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$ over the extended industrial temperature range $\left(-40^{\circ} \mathrm{C}\right.$ to $\left.+85^{\circ} \mathrm{C}\right)$ and is available in 14-pin plastic and ceramic DIP, plus SOL-16 and 20 -lead LCC surface mount packages.
Contact your local sales office for MIL-STD-883 data sheet and availability.


PIN CONNECTIONS
14-Lead Ceramic DIP (Y Suffix) and 14-Lead Epoxy DIP (P Suffix)


## OP467-SPECIFICATIONS <br> ELECTRICAL CHARACTERISTICS (@ $\mathrm{v}_{\mathrm{s}}= \pm 15.0 \mathrm{v}, \mathrm{r}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT CHARACTERISTICS <br> Offset Voltage <br> Input Bias Current <br> Input Offset Current <br> Common-Mode Rejection <br> Large Signal Voltage Gain <br> Offset Voltage Drift <br> Bias Current Drift <br> Long Term Offset Voltage Drift | $\mathrm{V}_{\mathrm{os}}$ $\mathrm{I}_{\mathrm{B}}$ <br> $\mathrm{I}_{\mathrm{OS}}$ <br> CMR <br> CMR <br> Avo <br> $\Delta \mathrm{V}_{\mathrm{OS}} / \Delta \mathrm{T}$ <br> $\Delta \mathrm{I}_{\mathrm{B}} / \Delta \mathrm{T}$ <br> $\Delta \mathrm{V}_{\mathrm{OS}} / \Delta \mathrm{T}$ | $\begin{aligned} & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{CM}}= \pm 12 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CM}}= \pm 12 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega,-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \end{aligned}$ <br> Note 1 | $\begin{aligned} & 80 \\ & 80 \\ & 83 \\ & 77.5 \end{aligned}$ | $\begin{aligned} & 0.2 \\ & \\ & 150 \\ & 150 \\ & 10 \\ & 10 \\ & 90 \\ & 88 \\ & 86 \\ & \\ & 3.5 \\ & 0.2 \end{aligned}$ | $\begin{aligned} & 0.5 \\ & 1 \\ & 600 \\ & 700 \\ & 100 \\ & 150 \\ & \\ & \\ & \hline 750 \end{aligned}$ | $\begin{aligned} & \mathrm{mV} \\ & \mathrm{mV} \\ & \mathrm{nA} \\ & \mathrm{nA} \\ & \mathrm{nA} \\ & \mathrm{nA} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \\ & \mu \mathrm{~V} /{ }^{\circ} \mathrm{C} \\ & \mathrm{pA} /{ }^{\circ} \mathrm{C} \\ & \mu \mathrm{~V} \end{aligned}$ |
| OUTPUT CHARACTERISTICS Output Voltage Swing | $\mathrm{V}_{\mathrm{O}}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega,-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \end{aligned}$ | $\begin{aligned} & \pm 13.0 \\ & \pm 12.9 \end{aligned}$ | $\begin{aligned} & \pm 13.5 \\ & \pm 13.12 \end{aligned}$ |  | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |
| POWER SUPPLY <br> Power Supply Rejection Ratio <br> Supply Current <br> Supply Voltage Range | PSRR <br> $I_{S Y}$ $\mathrm{V}_{\mathrm{s}}$ | $\begin{aligned} & \pm 4.5 \mathrm{~V} \leq \mathrm{V}_{\mathrm{S}}= \pm 18 \mathrm{~V} \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{O}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{O}}=0 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \end{aligned}$ | 96 <br> 86 $\pm 4.5$ | $\begin{aligned} & 120 \\ & 115 \\ & 8 \end{aligned}$ | $\begin{aligned} & 10 \\ & 13 \\ & \pm 18 \end{aligned}$ | dB <br> dB <br> mA <br> mA <br> V |
| DYNAMIC PERFORMANCE Gain Bandwidth Product Slew Rate <br> Full-Power Bandwidth Settling Time Phase Margin Input Capacitance Common Mode Differential | GBP <br> SR <br> $\mathrm{BW}_{\mathrm{p}}$ <br> $\mathrm{t}_{\mathrm{s}}$ <br> $\theta_{0}$ | $\begin{aligned} & \mathrm{A}_{\mathrm{V}}=+1, \mathrm{C}_{\mathrm{L}}=30 \mathrm{pF} \\ & \mathrm{~V}_{\mathrm{IN}}=10 \mathrm{~V} \text { Step, } \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=30 \mathrm{pF} \\ & \mathrm{~A}_{\mathrm{V}}=+1 \\ & \mathrm{~A}_{\mathrm{V}}=-1 \\ & \mathrm{~V}_{\mathrm{IN}}=10 \mathrm{~V} \text { Step } \\ & \text { To } 0.01 \%, \mathrm{~V}_{\mathrm{IN}}=10 \mathrm{~V} \text { Step } \end{aligned}$ | $125$ | $\begin{aligned} & 28 \\ & 170 \\ & 350 \\ & 2.7 \\ & 200 \\ & 45 \\ & \\ & 2.0 \\ & 1.0 \end{aligned}$ |  | MHz <br> $\mathrm{V} / \mu \mathrm{s}$ <br> V/ $/$ s <br> MHz <br> ns <br> Degrees <br> pF <br> pF |
| NOISE PERFORMANCE <br> Voltage Noise Voltage Noise Density Current Noise Density | $\begin{aligned} & e_{N} p-p \\ & e_{N} \\ & i_{N} \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{f}=0.1 \mathrm{~Hz} \text { to } 10 \mathrm{~Hz} \\ & \mathrm{f}=1 \mathrm{kHz} \\ & \mathrm{f}=1 \mathrm{kHz} \end{aligned}$ |  | $\begin{aligned} & 0.15 \\ & 6 \\ & 8 \\ & \hline \end{aligned}$ | \% | $\begin{aligned} & \mu \mathrm{V} \text { p-p } \\ & \mathrm{nV} / \sqrt{\mathrm{Hz}} \\ & \mathrm{pA} / \sqrt{\mathrm{Hz}} \end{aligned}$ |

## NOTE

${ }^{1}$ Long Term Offset Voltage Drift is guaranteed by 1000 hrs . Life test performed on three independent wafer lots at $+125^{\circ} \mathrm{C}$, with an LTPD of 1.3 .
Specifications subject to change without notice.

ELECTRICAL CHARACTERISTICS (@ $V_{S}= \pm 5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)


[^202]
## WAFER TEST LIMTS ( $\mathrm{V}_{\mathrm{S}}= \pm 15.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted.)

| Parameter | Symbol | Conditions | Limit | Units |
| :---: | :---: | :---: | :---: | :---: |
| Offset Voltage | $\mathrm{V}_{\text {Os }}$ |  | $\pm 0.5$ | mV max |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | 600 | $n A$ max |
| Input Offset Current | $\mathrm{I}_{\text {OS }}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | 100 | $n A \max$ |
| Input Voltage Range ${ }^{1}$ |  |  | $\pm 12$ | V min/max |
| Common-Mode Rejection Ratio | CMRR | $\mathrm{V}_{\mathrm{CM}}= \pm 12 \mathrm{~V}$ | 80 | dB min |
| Power Supply Rejection Ratio | PSRR | $\mathrm{V}= \pm 4.5 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | 96 | dB min |
| Large Signal Voltage Gain | $\mathrm{A}_{\text {vo }}$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | 83 | dB min |
| Output Voltage Range | $\mathrm{V}_{0}$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | $\pm 13.0$ | $V$ min |
| Supply Current | $\mathrm{I}_{\text {SY }}$ | $\mathrm{V}_{\mathrm{O}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=\infty$ | 10 | mA max |

## NOTES

Electrical tests and wafer probe to the limits shown. Due to variations in assembly methods and normal yield loss, yield after packaging is not guaranteed for standard product dice. Consult factory to negotiate specifications based on dice lot qualifications through sample lot assembly and testing.
${ }^{1}$ Guaranteed by CMR test.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

| Supply Voltage Input Voltage ${ }^{2}$ | $\pm 18 \mathrm{~V}$ |
| :---: | :---: |
|  | Input Voltage ${ }^{2}$. . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 18$ V |
| Differential Input Voltage ${ }^{2}$. . . . . . . . . . . . . . . . . . . $\pm 26$ V |  |
| Output Short-Circuit Duration . . . . . . . . . . . . . . . Limited |  |
| Storage Temperature Range |  |
| Y, RC Packages . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+175^{\circ} \mathrm{C}$ |  |
| P, S Packages . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |  |
| Operating Temperature Range |  |
| OP-467A . . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  |
| OP-467G . . . . . . . . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |
| Junction Temperature Range |  |
| Y, RC Packages . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+175^{\circ} \mathrm{C}$ |  |
| P, S Packages . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |  |
|  | $+300^{\circ} \mathrm{C}$ |


| Package Type | $\boldsymbol{\theta}_{\mathbf{J A}}{ }^{\mathbf{3}}$ | $\boldsymbol{\theta}_{\mathbf{J C}}$ | Units |
| :--- | :--- | :--- | :--- |
| 14-Pin Cerdip (Y) | 94 | 10 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 14-Pin Plastic DIP (P) | 76 | 33 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 16-Pin SOL (S) | 88 | 23 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 20-Contact LCC (RC) | 78 | 33 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTES

${ }^{1}$ Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
${ }^{2}$ For supply voltages less than $\pm 18 \mathrm{~V}$, the absolute maximum input voltage is equal to the supply voltage.
${ }^{3} \theta_{\mathrm{JA}}$ is specified for the worst case conditions, i.e., $\theta_{\mathrm{JA}}$ is specified for device in socket for cerdip, P-DIP, and LCC packages; $\theta_{\mathrm{JA}}$ is specified for device soldered in circuit board for SOIC package.

## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| OP467AY/883 | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 14-Pin Cerdip | Q-14 |
| OP467ARC $/ 883$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 20-Contact LCC | E-20A |
| OP467GP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 14-Pin Plastic DIP | N-14 |
| OP467GS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 16-Pin SOL | R-16 |
| OP467GBC | $+25^{\circ} \mathrm{C}$ | DICE |  |

*For outline information see Package Information section.

## DICE CHARACTERISTICS



OP-467 Die Size 0.111 X 0.100 inch, 11,100 sq. mils Substrate is Connected to V+, Number of Transistors 165.


Figure 1. Open-Loop Gain, Phase vs. Frequency


Figure 2. Closed-Loop Gain vs. Frequency


Figure 3. Open-Loop Gain vs. Supply Voltage


Figure 4. Closed-Loop Output Impedance vs. Frequency


Figure 5. Gain Linearity vs. Frequency


Figure 6. Max $V_{\text {out }}$ Swing vs. Frequency

## 0P467-Typical Characteristics



Figure 7. Max $V_{\text {Out }}$ Swing vs. Frequency


Figure 8. Common-Mode Rejection vs. Frequency


Figure 9. Power-Supply Rejection vs. Frequency


Figure 10. Small Signal Overshoot vs. Load Capacitance


Figure 11. Small Signal Overshoot vs. Load Capacitance


Figure 12. Noninverting Gain vs. Capacitive Loads


Figure 13. Channel Separation vs. Frequency


Figure 14. Input Current Noise Density vs. Frequency


Figure 15. Voltage Noise Density vs. Frequency


Figure 16. Settling Time, Negative Edge


Figure 17. Settling Time, Positive Edge


Figure 18. Input Voltage Range vs. Supply Voltage

## OP467-Typical Characteristics



Figure 19. Noninverting Gain vs. Supply Voltage


Figure 20. Output Swing vs. Load Resistance


Figure 21. Output Swing vs. Load Resistance


Figure 22. Input Offset Voltage Distribution


Figure 23. Input Offset Voltage Distribution


Figure 24. TC V Os $^{\text {Distribution }}$


Figure 25. TC $V_{\text {OS }}$ Distribution


Figure 26. Phase Margin \& Gain Bandwidth vs. Temperature


Figure 27. Slew Rate vs. Temperature


Figure 28. Slew Rate vs. Temperature


Figure 29. Slew Rate vs. Temperature


Figure 30. Slew Rate vs. Temperature


Figure 31. Settling Time vs.. Output Step


Figure 32: Supply Current vs. Supply Voltage


Figure 33. Input Bias Current vs. Temperature


Figure 34. Input Offset Current vs. Temperature

## APPLICATIONS INFORMATION

OUTPUT SHORT-CIRCUIT PERFORMANCE
To achieve a wide bandwidth and high slew rate, the OP-467 output is not short circuit protected. Shorting the output to ground or to the supplies may destroy the device.
For safe operation, the output load current should be limited so that the junction temperature does not exceed the absolute maximum junction temperature.
To calculate the maximum internal power dissipation, following formula can be used:

$$
P D=\frac{T_{y} \max -T_{A}}{\theta_{Y_{A}}}
$$

where $T_{J}$ and $T_{A}$ are junction and ambient temperatures respectively, PD is device internal power dissipation, and $\theta_{\mathrm{JA}}$ is packaged device thermal resistance given in the data sheet.

## UNUSED AMPLIFIERS

It is recommended that any unused amplifiers in a quad package be connected as a unity gain follower with a $1 \mathrm{k} \Omega$ feedback resistor with noninverting input tied to the ground plain.

## PRINTED CIRCUIT BOARD LAYOUT CONSIDERATIONS

Satisfactory performance of a high speed op amp largely depends on a good PC layout. To achieve the best dynamic performance, following high frequency layout technique is recommended.

## GROUNDING

A good ground plain is essential to achieve the optimum performance in high speed applications. It can significantly reduce the undesirable effects of ground loops and IR drops by providing a low impedance reference point. Best results are obtained with a multilayer board design with one layer assigned to ground plain. To maintain a continuous and low impedance ground, avoid running any traces on this layer.

## POWER SUPPLY CONSIDERATIONS

In high frequency circuits, device lead length introduces an inductance in series with the circuit. This inductance combined with stray capacitance forms a high frequency resonance circuit. Poles generated by these circuits will cause gain peaking and additional phase shift reducing the op amp's phase margin and leading to an unstable operation.
A practical solution to this problem is to reduce the resonance frequency low enough to take advantage of the amplifier's power supply rejection.
This is easily done by placing capacitors across the supply line and the ground plain as close as possible to the device pin. Since capacitors also have internal parasitic components, such as stray inductance, selecting the right capacitor is important. To be effective, they should have low impedance over the frequency range of interest. Tantalum capacitors are an excellent choice for their high capacitance/size ratio, but their ESR (Effective Series Resistance) increases with frequency making them less effective. On the other hand, ceramic chip capacitors have excellent ESR and ESL (Effective Series Inductance) performance at higher frequencies, and because of their small size, they can be placed very close to the device pin, further reducing the stray inductance. Best results are achieved by using a combination of these two capacitors. A $5-10 \mu \mathrm{~F}$ tantalum parallel with a $0.1 \mu \mathrm{~F}$ ceramic chip caps are recommended. If additional isolation from high frequency resonances of the power supply is needed, a ferrite bead should be placed in series with the supply lines between the bypass caps and the power supply. A word of caution, addition of the ferrite bead will introduce a new pole and zero to frequency response of the circuit and could cause unstable operation if it is not selected properly.


Figure 35. Recommended Power Supply Bypass

## SIGNAL CONSIDERATIONS

Input and output traces need special attention to assure a minimum stray capacitance. Input nodes are very sensitive to capacitive reactance, particularly when connected to a high impedance circuit. Stray capacitance can inject undesirable signals from a noisy line into a high impedance input. Protect high impedance input traces by providing guard traces around them. This will also improve the channel separation significantly.

Additionally, any stray capacitance in parallel with the op amp's input capacitance generates a pole in the frequency response of the circuit. The additional phase shift caused by this pole will reduce the circuit's gain margin. If this pole is within the gain range of the op amp, it will cause unstable performance. To reduce these undesirable effects, use the lowest impedance where possible. Lowering the impedance at this node places the poles at a higher frequency, far above the gain range of the amplifier. Stray capacitance on the PC board can be reduced by making the traces narrow and as short as possible. Further reduction can be realized by choosing smaller pad size, increasing the spacing between the traces, and using PC board material with a low dielectric constant insulator (Dielectric Constant of some common insulators: air $=1$, Teflon $=2.2$, and FR4 $=$ 4.7; with air being an ideal insulator).

Removing segments of the ground plain directly under the input and output pads is recommended.
Outputs of high speed amplifiers are very sensitive to capacitive loads. A capacitive load will introduce a pair of pole and zero to the circuit's frequency response, reducing the phase margin, leading to unstable operation or oscillation.
Generally, it is a good design practice to isolate the amplifier's output from any capacitive load by placing a resistor between the amplifier's output and the rest of the circuits. A series resistor of 10 to 100 ohms is normally sufficient to isolate the output from a capacitive load.
The OP-467 is internally compensated to provide stable operation, and is capable of driving large capacitive loads without oscillation.
Sockets are not recommended since they increase the lead inductance/capacitance and reduce the power dissipation of the package by increasing the leads thermal resistance. If sockets must be used, use Teflon» or pin sockets with the shortest leads possible.

## PHASE REVERSAL

The OP-467 is immune to phase reversal; its inputs can exceed the supply rails by a diode drop without any phase reversal.
$\star$ Teflon is a registered trademark of E.I. du Pont Co.


Figure 36. No Phase Reversal $\left(A_{V}=+1\right)$

## SATURATION RECOVERY TIME

The OP-467 has a fast and symmetrical recovery time from either rail. This feature is very useful in applications such as high speed instrumentation and measurement circuits, where the amplifier is frequently exposed to large signals that overload the amplifier.


Figure 37. Saturation Recovery Time, Positive Rail


Figure 38. Saturation Recovery Time, Negative Rail

## HIGH SPEED INSTRUMENTATION AMPLIFIER

The OP-467 performance lends itself to a variety of high speed applications, including high speed precision instrumentation amplifiers. Figure 39 represents a circuit commonly used for data acquisition, CCD imaging, and other high speed application.
Circuit gain is set by $\mathbf{R}_{\mathbf{G}}$. A $2 \mathrm{k} \Omega$ resistor will set the circuit gain to 2 , for unity gain, remove $R_{G}$. For any other gain settings use the following formula:

$$
G=2 / R_{G} \quad \text { Resistor Value is in } k \Omega
$$

$\mathbf{R}_{\mathbf{C}}$ is used for adjusting the dc common-mode rejection, and $\mathrm{C}_{\mathrm{C}}$ is used for ac common-mode rejection adjustments.


Figure 39. A High Speed Instrumentation Amplifier


Figure 40. Instrumentation Amplifier Settling Time to $0.01 \%$ for a 10 V Step Input (Negative Slope)


Figure 41. Instrumentation Amplifier Settling Time to $0.01 \%$ for a 10 V Step Input (Positive Slope)


Figure 42. Settling Time Measurement Circuit

## 2 MHz BIQUAD BANDPASS FILTER

The circuit in Figure 43 is commonly used in medical imaging ultrasound receivers. The 30 MHz bandwidth is sufficient to accurately produce the 2 MHz center frequency, as the measured response shows in Figure 44. When the op amp's bandwidth is too close to the filter's center frequency, the amplifier's internal phase shift causes excess phase shift at 2 MHz , which alters the filter's response. In fact, if the chosen op amp has a bandwidth close to 2 MHz , the combined phase shift of the three op amps will cause the loop to oscillate.
Careful consideration must be given to the layout of this circuit as with any other high speed circuit.
If the phase shift introduced by the layout is large enough, it could alter the circuit performance, or worse, it will oscillate.


Figure 43. 2 MHz Biquad Filter


Figure 44. Biquad Filter Response


Figure 45. Quad DAC Unipolar Operation

## FAST I-TO-V CONVERTER

The fast slew rate and fast settling time of the OP-467 are well suited to the fast buffers and I-to-V converters used in variety of applications. The circuit in Figure 45 is a unipolar quad D/A converter consisting of only two ICs. The current output of the DAC-8408 is converted to a voltage by the OP-467 configured as an I-to-V converter. This circuit is capable of settling to $0.1 \%$ within 200 ns. Figures 46 and 47 show the full-scale settling time of the outputs. To obtain reliable circuit performance, keep the traces from the DAC's $\mathrm{I}_{\text {OUT }}$ to the inverting inputs of the OP-467 short to minimize parasitic capacitance.


Figure 46. Voltage Output Settling Time


Figure 47. Voltage Output Settling Time


Figure 48. DAC Vout Settling Time Circuit

OP-467 SPICE MACRO-MODEL

* Node assignments
* $\left.\left.\quad\right|_{\text {. }}\right|_{\text {noninverting input }} ^{\text {inverting input }}$
* INPUT STAGE

| I1 | 4 | 50 | 10E-3 |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| CIN | 1 | 2 | $1 \mathrm{E}-12$ |  |  |
| IOS | 1 | 2 | 5E-9 |  |  |
| Q1 | 5 | 2 | 8 QN |  |  |
| Q2 | 6 | 7 | 9 QN |  |  |
| R3 | 99 | 5 | 185.681 |  |  |
| R4 | 99 | 6 | 185.681 |  |  |
| R5 | 8 | 4 | 180.508 |  |  |
| R6 | 9 | 4 | 180.508 |  |  |
| EOS | 7 | 1 | POLY (1) | $(14,20)$ | 50E-6 1 |
| EREF | 98 | 0 | $(20,0) 1$ |  |  |

* GAIN STAGE AND DOMINANT POLE AT 1.5 kHz

| R7 | 10 | 98 | 3.714 E 6 |
| :--- | :--- | :--- | :--- |
| C2 | 10 | 98 | $28.571 \mathrm{E}-12$ |
| G1 | 98 | 10 | $(5,6)$ |
| V1 | 99 | 11 | 1.6 |
| V2 | 12 | 50 | 1.6 |
| D1 | 10 | 11 | DX |
| D2 | 12 | 10 | DX |
| RC | 10 | 28 | 1.4 E 3 |
| CC | 28 | 27 | $12 \mathrm{E}-12$ |

* COMMON-MODE STAGE WITH ZERO AT 1.26 kHz *

| ECM | 13 | 98 | POLY (2) | $(1,20)$ | $(2,20)$ | 0 | 0.5 | 0.5 |  |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| R8 | 13 | 14 | 1E6 |  |  |  |  |  |  |
| R9 | 14 | 98 | 25.119 |  |  |  |  |  |  |
| C3 | 13 | 14 | $126.721 \mathrm{E}-12$ |  |  |  |  |  |  |

夫

* POLE AT 400E6

| R10 | 15 | 98 | 1 E 6 |
| :--- | :--- | :--- | :--- |
| C4 | 15 | 98 | $0.398 \mathrm{E}-15$ |
| G2 | 98 | 15 | $(10,20) 1 \mathrm{E}-6$ |

## * OUTPUT STAGE

| ISY | 99 | 50 | $-8 \cdot 183 \mathrm{E}-3$ |
| :--- | :--- | :--- | :--- |
| RMP1 | 99 | 20 | $96 \cdot 429 \mathrm{E} 3$ |
| RMP2 | 20 | 50 | 96.429 E 3 |
| RO1 | 99 | 26 | 200 |
| RO2 | 26 | 50 | 200 |
| L1 | 26 | 27 | $1 \mathrm{E}-7$ |
| GO1 | 26 | 99 | $(99,15)$ |
| GE-3 |  |  |  |
| GO2 | 50 | 26 | $(15,50)$ |
| $5 \mathrm{E}-3$ |  |  |  |
| G4 | 23 | 50 | $(15,26)$ |
| $5 \mathrm{E}-3$ |  |  |  |
| G5 | 24 | 50 | $(26,15)$ |
| $5 \mathrm{E}-3$ |  |  |  |
| V3 | 21 | 26 | 50 |
| V4 | 26 | 22 | 50 |
| D3 | 15 | 21 | DX |
| D4 | 22 | 15 | DX |
| D5 | 99 | 23 | DX |
| D6 | 99 | 24 | DX |
| D7 | 50 | 23 | DY |
| D8 | 50 | 24 | DY |

* 
* MODELS USED
* 

. MODEL QN NPN (BF=33.333E3)
. MODEL DX D
. MODEL DY D (BV=50)
. ENDS OP-467


Figure 49. Spice Macro-Model Output Stage


Figure 50. Spice Macro-Model Input and Gain Stage

## FEATURES

- Very Low Noise $\qquad$ $5 n V / \sqrt{H z} @ 1 \mathrm{kHz}$ Max
- Excellent Input Offset Voltage ................ . 0.4mV Max
- Low Offset Voltage Drift . . . . . . . . . . . . . . . . . . . . $2 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ Max
- Very High Gain . . . . . . . . . . . . . . . . . . . . . . . . . . 1000V/mV Min
- Outstanding CMR 110dB Min
- Slew Rate 2V/ $\mu$ s Typ
- Gain-Bandwidth Product 6MHz Typ
- Industry Standard Quad Pinouts
- Available in Die Form


## ORDERING INFORMATION ${ }^{\dagger}$

| $\begin{gathered} T_{A}=+25^{\circ} \mathrm{C} \\ \hat{V}_{\text {Os }} \operatorname{MAX}_{(\mu \mathrm{V}} \end{gathered}$ | PACKAGE |  |  | operating TEMPERATURE RANGE |
| :---: | :---: | :---: | :---: | :---: |
|  | $\begin{aligned} & \text { CERDIP } \\ & \text { 14-PIN } \end{aligned}$ | PLASTIC | LCC |  |
| 400 | - | - | OP470ARC/883 | MIL |
| 400 | OP470AY* | - | OP470ATC/883 | M ${ }^{\text {L }}$ |
| 400 | OP470EY | - | - | IND |
| 800 | OP470FY | - | - | IND |
| 1000 | - | OP470GP | - | XIND |
| 1000 | - | OP470GS" | - | XIND |

- For devices processed in total compliance to MIL-STD-883, add /883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.
It For availability and burn-in information on SO and PLCC packages, contact your local sales office.


## GENERAL DESCRIPTION

The OP-470 is a high-performance monolithic quad operational amplifier with exceptionally low voltage noise, $5 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ at 1 kHz Max, offering comparable performance to PMI's industry standard OP-27.
The OP-470 features an input offset voltage below 0.4 mV , excellent for a quad op amp, and an offset drift under $2 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$, guaranteed over the full military temperature range. Openloop gain of the OP-470 is over $1,000,000$ into a $10 \mathrm{k} \Omega$ load

## PIN CONNECTIONS


insuring excellent gain accuracy and linearity, even in highgain applications. Input bias current is under 25nA which reduces errors due to signal source resistance. The OP-470's CMR of over 110 dB and PSRR of less than $1.8 \mu \mathrm{~V} / \mathrm{V}$ significantly reduce errors due to ground noise and power supply fluctuations. Power consumption of the quad OP-470 is half that of four OP-27s, a significant advantage for power con-

## SIMPLIFIED SCHEMATIC



This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.
scious applications. The OP-470 is unity-gain stable with a gain-bandwidth product of 6 MHz and a slew rate of $2 \mathrm{~V} / \mu \mathrm{s}$.
The OP-470 offers excellent amplifier matching which is important for applications such as multiple gain blocks, lownoise instrumentation amplifiers, quad buffers, and low-noise active filters.

The OP-470 conforms to the industry standard 14-pin DIP pinout. It is pin compatible with the OP-11, LM148/149, HA4741, HA5104, and RM4156 quad op amps and can be used to upgrade systems using these devices.

For higher speed applications the OP-471, with a slew rate of $8 \mathrm{~V} / \mu \mathrm{s}$, is recommended.

## ABSOLUTE MAXIMUM RATINGS (Note 1)

Supply Voltage ................................................................ $\pm 18 \mathrm{~V}$
Differential Input Voltage (Note 2) .................................. $\pm 1.0 \mathrm{~V}$
Differential Input Current (Note 2) ................................. $\pm 25 \mathrm{~mA}$
Input Voltage ..................................................... Supply Voltage
Output Short-Circuit Duration Continuous
Storage Temperature Range
P, TC, Y-Package $\qquad$ $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

Lead Temperature Range (Soldering, 60 sec ) .............. $300^{\circ} \mathrm{C}$ Junction Temperature ( $\mathrm{T}_{\mathrm{i}}$ ) ............................ $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ Operating Temperature Range
OP-470A .................................................... $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
OP-470E, OP-470F ................................... $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
OP-470G ...................................................... $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$

| PACKAGE TYPE | $\Theta_{\text {IA }}($ Note 3) | $\boldsymbol{\Theta}_{\text {IC }}$ | UNITS |
| :--- | :---: | :---: | :---: |
| 14-Pin Hermetic DIP (Y) | 94 | 10 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 14-Pin Plastic DIP (P) | 76 | 33 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $20-$ Contact LCC (RC) | 78 | 30 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $28-$ Contact LCC (TC) | 70 | 28 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $16-$ Pin SOL (S) | 88 | 23 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| NOTES: |  |  |  |

NOTES:

1. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
2. The OP-470's inputs are protected by back-to-back diodes. Current limiting resistors are not used in order to achieve low noise performance. If differential voltage exceeds $\pm 1.0 \mathrm{~V}$, the input current should be limited to $\pm 25 \mathrm{~mA}$.
3. $\Theta_{i A}$ is specified for worst case mounting conditions, i.e., $\Theta_{i A}$ is specified for device in socket for TO, CerDIP, P-DIP, and LCC packages; $\Theta_{j A}$ is specified for device soldered to printed circuit board for SO and PLCC packages.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-470A/E |  |  | OP-470F |  |  | OP-470G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Input Offset Voltage | $\mathrm{V}_{\mathrm{OS}}$ |  | - | 0.1 | 0.4 | - | 0.2 | 0.8 | - | 0.4 | 1.0 | mV |
| Input Offset Current | los | $\mathrm{V}_{C M}=0 \mathrm{~V}$ | - | 3 | 10 | - | 6 | 20 | - | 12 | 30 | $n \mathrm{~A}$ |
| Input Bias Current | $I_{B}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 6 | 25 | - | 15 | 50 | - | 25 | 60 | $n \mathrm{~A}$ |
| Input Noise Voltage | $e_{\text {np-p }}$ | 0.1 Hz to 10 Hz (Note 1) | - | 80 | 200 | - | 80 | 200 | - | 80 | 200 | $n V_{p-p}$ |
| Input Noise Voltage Density | $e_{n}$ | $\mathrm{f}_{\mathrm{O}}=10 \mathrm{~Hz}$ | - | 3.8 | 6.5 | - | 3.8 | 6.5 | - | 3.8 | 6.5 |  |
|  |  | $\mathrm{f}_{\mathrm{O}}=100 \mathrm{~Hz}$ | - | 3.3 | 5.5 | - | 3.3 | 5.5 | - | 3.3 | 5.5 | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
|  |  | $f_{O}=1 \mathrm{kHz}$ <br> (Note 2) | - | 3.2 | 5.0 | - | 3.2 | 5.0 | - | 3.2 | 5.0 | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| Input Noise Current Density | $i_{n}$ | $\mathrm{f}_{\mathrm{O}}=10 \mathrm{~Hz}$ | - | 1.7 | - | - | 1.7 | - | - | 1.7 | - |  |
|  |  | $\mathrm{f}_{\mathrm{O}}=100 \mathrm{~Hz}$ | - | 0.7 | - | - | 0.7 | - | - | 0.7 | - | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
|  |  | $\mathrm{f}_{\mathrm{O}}=1 \mathrm{kHz}$ | - | 0.4 | - | - | 0.4 | - | - | 0.4 | - |  |
| Large-Signal Voltage Gain | Avo | $\mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V}$ | $\begin{array}{r} 1000 \\ 500 \end{array}$ | $\begin{aligned} & 2300 \\ & 1200 \end{aligned}$ | - | $\begin{aligned} & 800 \\ & 400 \end{aligned}$ | $\begin{array}{r} 1700 \\ 900 \end{array}$ | - | $\begin{aligned} & 800 \\ & 400 \end{aligned}$ | $\begin{array}{r} 1700 \\ 900 \end{array}$ | - | $\mathrm{V} / \mathrm{mV}$ |
|  |  | $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ |  |  |  |  |  |  |  |  |  |  |
|  |  | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ |  |  |  |  |  |  |  |  |  |  |
| Input Voltage Range | IVR | (Note 3) | $\pm 11$ | $\pm 12$ | - | $\pm 11$ | $\pm 12$ | - | $\pm 11$ | $\pm 12$ | - | V |
| Output Voltage Swing | $\mathrm{V}_{0}$ | $\mathrm{R}_{\mathrm{L}} \geq 2 \mathrm{k} \Omega$, | $\pm 12$ | $\pm 13$ | - | $\pm 12$ | $\pm 13$ | - | $\pm 12$ | $\pm 13$ | - | V |
| Common-Mode Rejection CMR |  | $\mathrm{V}_{\mathrm{CM}}= \pm 11 \mathrm{~V}$ | 110 | 125 | - | 100 | 120 | - | 100 | 120 | - | dB |
| Power Supply Rejection Ratio | PSRR | $V_{S}= \pm 4.5 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | 0.56 | 1.8 | - | 1.0 | 5.6 | - | 1.0 | 5.6 | $\mu \mathrm{V} / \mathrm{V}$ |
| Slew Rate | SR |  | 1.4 | 2 | - | 1.4 | 2 | - | 1.4 | 2 | - | $\mathrm{V} / \mu \mathrm{s}$ |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted. (Continued)

| PARAMETER | SYMBOL | CONDITIONS | OP-470A/E |  |  | OP-470F |  |  | OP-470G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Supply Current (All Amplifiers) | $I_{\text {SY }}$ | No Load | - | 9 | 11 | - | 9 | 11 | - | 9 | 11 | mA |
| Gain Bandwidth Product | GBW | $A_{V}=+10$ | - | 6 | - | - | 6 | - | - | 6 | - | MHz |
| Channel Separation | CS | $\begin{aligned} & \mathrm{V}_{\mathrm{O}}=20 \mathrm{~V}_{\mathrm{p}-\mathrm{p}} \\ & f_{\mathrm{O}}=10 \mathrm{~Hz} \text { (Note 1) } \end{aligned}$ | 125 | 155 | - | 125 | 155 | - | 125 | 155 | - | dB |
| Input Capacitance | $\mathrm{C}_{\text {IN }}$ | . | - | 2 | - | - | 2 | - | - | 2 | - | pF |
| Input Resistance Differential-Mode | $\mathrm{R}_{\text {IN }}$ |  | - | 0.4 | - | - | 0.4 | - | - | 0.4 | - | M $\Omega$ |
| Input Resistance Common-Mode | $\mathrm{R}_{\text {INCM }}$ |  | - | 11 | - | - | 11 | - | - | 11 | - | G $\Omega$ |
| Settling Time | $\mathrm{t}_{\mathrm{s}}$ | $\begin{aligned} & A_{V}=+1 \\ & \text { to } 0.1 \% \\ & \text { to } 0.01 \% \end{aligned}$ | - | 5.5 6.0 | - | - | 5.5 6.0 | - | - | 5.5 6.0 | - | $\mu \mathrm{S}$ |

## NOTES:

1. Guaranteed but not $100 \%$ tested.
2. Sample tested.
3. Guaranteed by CMR test.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V},-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq 125^{\circ} \mathrm{C}$ for $\mathrm{OP}-470 \mathrm{~A}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-470A |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX |  |
| Input Offset Voitage | $\mathrm{V}_{\text {OS }}$ |  | - | 0.14 | 0.6 | mV |
| Average Input Offset Voltage Drift | $\mathrm{TCV}_{\text {Os }}$ |  | - | 0.4 | 2 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current | los | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 5 | 20 | nA |
| Input Bias Current | $1_{B}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 15 | 50 | nA |
| Large-Signal Voltage Gain | $A_{\text {vo }}$ | $\begin{gathered} \mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \\ \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \\ \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ \hline \end{gathered}$ | $\begin{aligned} & 750 \\ & 400 \\ & \hline \end{aligned}$ | $\begin{array}{r} 1600 \\ 800 \\ \hline \end{array}$ | - | V/mV |
| Input Voltage Range | IVR | (Note 1) | $\pm 11$ | $\pm 12$ | - | V |
| Output Voltage Swing | $\mathrm{V}_{\mathrm{O}}$ | $R_{L} \geq 2 \mathrm{k} \Omega$ | $\pm 12$ | $\pm 13$ | - | V |
| Common-Mode Rejection | CMR | $\mathrm{V}_{\mathrm{CM}}= \pm 11 \mathrm{~V}$ | 100 | 120 | - | dB |
| Power Supply Rejection Ratio | PSRR | $\mathrm{V}_{\mathrm{S}}= \pm 4.5 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | 1.0 | 5.6 | $\mu \mathrm{V} / \mathrm{V}$ |
| Supply Current (All Amplifiers) | Isy | No Load | - | 9.2 | 11 | mA |

NOTE:

1. Guaranteed by CMR test.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V},-25^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ for OP-470E/F, $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{A} \leq+85^{\circ} \mathrm{C}$ for $\mathrm{OP}-470 \mathrm{G}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-470E |  |  | OP-470F |  |  | OP-470G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Input Offset Voltage | $\mathrm{V}_{\mathrm{OS}}$ |  | - | 0.12 | 0.5 | - | 0.24 | 1.0 | - | 0.5 | 1.5 | mV |
| Average Input Offset Voltage Drift | $\mathrm{TCV}_{\text {Os }}$ |  | - | 0.4 | 2 | - | 0.6 | 4 | - | 2 | - | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current | los | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 4 | 20 | - | 7 | 40 | - | 20 | 50 | $n \mathrm{~A}$ |
| Input Bias Current | $I_{B}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 11 | 50 | - | 20 | 70 | - | 40 | 75 | $n \mathrm{~A}$ |
| Large-Signal Voltage Gain | $A_{\text {vo }}$ | $\begin{gathered} \mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \\ \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \\ \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \end{gathered}$ | 800 400 | $\begin{array}{r} 1800 \\ 900 \end{array}$ | - | $\begin{aligned} & 600 \\ & 300 \end{aligned}$ | $\begin{array}{r} 1400 \\ 700 \end{array}$ | - | $\begin{aligned} & 600 \\ & 300 \\ & \hline \end{aligned}$ | $\begin{array}{r} 1500 \\ 800 \\ \hline \end{array}$ | $-$ | $\mathrm{V} / \mathrm{mV}$ |
| Input Voltage Range | IVR | (Note 1) | $\pm 11$ | $\pm 12$ | - | $\pm 11$ | $\pm 12$ | - | $\pm 11$ | $\pm 12$ | - | V |
| Output Voltage Swing | $\mathrm{V}_{0}$ | $\mathrm{R}_{\mathrm{L}} \geq 2 \mathrm{k} \Omega$ | $\pm 12$ | $\pm 13$ | - | $\pm 12$ | $\pm 13$ | - | $\pm 12$ | $\pm 13$ | - | V |
| Common-Mode Rejection | CMR | $\mathrm{V}_{\mathrm{CM}}= \pm 11 \mathrm{~V}$ | 100 | 120 | - | 90 | 115 | - | 90 | 110 | - | dB |
| Power Supply Rejection Ratio | PSRR | $\mathrm{V}_{\mathrm{S}}= \pm 4.5 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | 0.7 | 5.6 | - | 1.8 | 10 | - | 1.8 | 10 | $\mu \mathrm{V} / \mathrm{V}$ |
| Supply Current (All Amplifiers) | $\mathrm{I}_{\text {Sr }}$ | No Load | - | 9.2 | 11 | - | 9.2 | 11 | - | 9.3 | 11 | mA |

NOTE:

1. Guaranteed by CMR test.

High Speed, Low Noise Quad Operational Amplifier

## FEATURES

- Excellent Speed
. $8 \mathrm{~V} / \mu \mathrm{s}$ Typ
- Low Noise $\qquad$ $11 n \mathrm{~V} / \sqrt{\mathrm{Hz}}$ @ 1 kHz Max
- Unity-Gain Stable
- High Gain-Bandwidth
6.5MHz Typ
- Low Input Offset Voltage . 0.8 mV Max
- Low Offset Voltage Drift $.4 \mu V /{ }^{\circ} \mathrm{C}$ Max
- High Gain 500V/mV Min
- Outstanding CMR 105 dB Min
- Industry Standard Quad Pinouts
- Avaiiable in Die Form

ORDERING INFORMATION ${ }^{\dagger}$

| $\begin{gathered} \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ \mathrm{~V}_{\mathrm{OS}} \mathrm{MAX} \\ (\mu \mathrm{~V}) \end{gathered}$ | PACKAGE |  |  | OPERATING TEMPERATURE RANGE |
| :---: | :---: | :---: | :---: | :---: |
|  | CERDIP | PLASTIC | LCC* |  |
| 800 | OP471AY* | - | OP471ATC/883 | MIL |
| 800 | - | - | OP471ARC/883 | MIL |
| 800 | OP471EY | - | - | IND |
| 1500 | OP471FY | - | - | IND |
| 1800 | - | OP471GP | - | XIND |
| 1800 | - | OP471GS ${ }^{\dagger \dagger}$ | - | XIND |

- For devices processed in total compliance to MIL-STD-883, add /883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.
\#t For availability and burn-in information on SO and PLCC packages, contact your local sales office.


## GENERAL DESCRIPTION

The OP-471 is a monolithic quad op amp featuring low noise, $11 \mathrm{nV} / \sqrt{\mathrm{Hz}} \mathrm{Max} @ 1 \mathrm{kHz}$, excellent speed, $8 \mathrm{~V} / \mu$ s typical, a gain-bandwidth of 6.5 MHz , and unity-gain stability.

## PIN CONNECTIONS



The OP-471 has an input offset voltage under 0.8 mV and an input offset voltage drift below $4 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$, guaranteed over the full military temperature range. Open loop gain of the OP-471 is over 500,000 into a $10 \mathrm{k} \Omega$ load insuring outstanding gain accuracy and linearity. The input bias current is under 25 nA

SIMPLIFIED SCHEMATIC (One of four amplifiers is shown.)


This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.
limiting errors due to signal source resistance. The OP-471's CMR of over 105 dB and PSRR of under $5.6 \mu \mathrm{~V} / \mathrm{V}$ significantly reduce errors caused by ground noise and power supply fluctuations.
The OP-471 offers excellent amplifier matching which is important for applications such as multiple gain blocks, lownoise instrumentation amplifiers, quad buffers and low-noise active filters.
The OP-471 conforms to the industry standard 14-pin DIP pinout. It is pin compatible with the OP-11, LM148/149, HA4741, RM4156, MC33074, TL084 and TL074 quad op amps and can be used to upgrade systems using these devices.
For applications requiring even lower voltage noise the OP470 , with a voltage density of $5 \mathrm{nV} / \sqrt{\mathrm{Hz}} \mathrm{Max} @ 1 \mathrm{kHz}$, is recommended.

ABSOLUTE MAXIMUM RATINGS (Note 1)
Supply Voltage ........................................................... $\pm 18 \mathrm{~V}$
Differential Input Voltage (Note 3) ............................... $\pm 1.0 \mathrm{~V}$
Differential Input Current (Note 3) ............................. $\pm 25 \mathrm{~mW}$
Input Voltage ................................................. Supply Voltage
Output Short-Circuit Duration ................................ Continuous Storage Temperature Range

Lead Temperature Range (Soldering, 60 sec ) ............... $300^{\circ} \mathrm{C}$ Junction Temperature ( $\mathrm{T}_{\mathrm{i}}$ ) ............................ $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ Operating Temperature Range


## NOTES:

1. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
2. $\Theta_{j \mu}$ is specified for worst case mounting conditions, i.e., $\Theta_{j A}$ is specified for device in socket for CerDIP, P-DIP, and LCC packages; $\boldsymbol{\Theta}_{j A}$ is specified for device soldered to printed circuit board for SOL package.
3. The OP-471's inputs are protected by back-to-back diodes. Current limiting resistors are not used in order to achieve low noise performance. If differential voltage exceeds $\pm 1.0 \mathrm{~V}$, the input current should be limited to $\pm 25 \mathrm{~mA}$.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-471A/E |  |  | OP-471F |  |  | OP-471G |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | UNITS |
| Input Offset Voltage | $\mathrm{V}_{\mathrm{OS}}$ |  | - | 0.25 | 0.8 | - | 0.5 | 1.5 | - | 1.0 | 1.8 | mV |
| Input Offset Current | Ios | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 4 | 10 | - | 7 | 20 | - | 12 | 30 | nA |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 7 | 25 | - | 15 | 50 | - | 25 | 60 | nA |
| Input Noise Voltage | $e_{n p-p}$ | 0.1 Hz to 10 Hz <br> (Note 1) | - | 250 | 500 | - | 250 | 500 | - | 250 | 500 | $n V_{p-p}$ |
| Input Noise Voltage Density | $e_{n}$ | $\mathrm{f}_{\mathrm{O}}=10 \mathrm{~Hz}$ | - | 9 | 16 | - | 9 | 16 | - | 9 | 16 | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
|  |  | $\mathrm{f}_{\mathrm{O}}=100 \mathrm{~Hz}$ | - | 7 | 12 | - | 7 | 12 | - | 7 | 12 |  |
|  |  | $\mathrm{f}_{\mathrm{O}}=1 \mathrm{kHz}$ <br> (Note 2) | - | 6.5 | 11 | - | 6.5 | 11 | - | 6.5 | $11$ |  |
| input Noise Current Density | $i_{n}$ | $\mathrm{f}_{\mathrm{O}}=10 \mathrm{~Hz}$ | - | 1.7 | - | - | 1.7 | - | - | 1.7 | - | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
|  |  | $\mathrm{f}_{\mathrm{O}}=100 \mathrm{~Hz}$ | - | 0.7 | - | - | 0.7 | - | - | 0.7 | - |  |
|  |  | $\mathrm{f}_{\mathrm{O}}=1 \mathrm{kHz}$ | - | 0.4 | - | - | 0.4 | - | - | 0.4 | - |  |
| Large-Signal Voltage Gain | $A_{\text {vo }}$ | $V_{0}= \pm 10 \mathrm{~V}$$R_{L}=10 \mathrm{k} \Omega$ |  |  |  |  |  |  |  |  |  | $\mathrm{V} / \mathrm{mV}$ |
|  |  |  | 500 | 700 | - | 300 | 500 | - | 300 | 500 | - |  |
|  |  |  | 350 | 550 | - | 175 | 275 | - | 175 | 275 | - |  |
| Input Voltage Range | IVR | (Note 3) | $\pm 11$ | $\pm 12$ | - | $\pm 11$ | $\pm 12$ | - | $\pm 11$ | $\pm 12$ | - | V |
| Output Voltage Swing | $\mathrm{V}_{\mathrm{O}}$ | $R_{L} \geq 2 k \Omega$ | $\pm 12$ | $\pm 13$ | - | $\pm 12$ | $\pm 13$ | - | $\pm 12$ | $\pm 13$ | - | V |
| Common-Mode Rejection CMR |  | $\begin{aligned} & V_{\mathrm{CM}}= \pm 11 \mathrm{~V} \\ & V_{\mathrm{S}}= \pm 4.5 \mathrm{~V} \text { to } \pm 18 \mathrm{~V} \end{aligned}$ | 105 | 120 | - | 95 | 115 | - | 95 | 115 | - | dB |
| Power Supply Rejection Ratio | PSRR |  | - | 1 | 5.6 | - | 5.6 | 17.8 | - | 5.6 | 17.8 | $\mu \mathrm{V} / \mathrm{V}$ |
| Slew Rate | SR |  | 6.5 | 8 | - | 6.5 | 8 | - | 6.5 | 8 | - | $\mathrm{V} / \mu \mathrm{s}$ |

## $0 P 471$

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{S}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted. (Continued)

| PARAMETER | SYMBOL | CONDITIONS | OP-471A/E |  |  | OP-471F |  |  | OP-471G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Supply Current (All Amplifiers) | $\mathrm{I}_{\text {SY }}$ | No Load | - | 9.2 | 11 | - | 9.2 | 11 | - | 9.2 | 11 | mA |
| Gain-Bandwidth Product | GBW | $A_{V}=+10$ | - | 6.5 | - | - | 6.5 | - | - | 6.5 | - | MHz |
| Channel Separation | CS | $\begin{aligned} & \mathrm{V}_{\mathrm{O}}=20 \mathrm{~V}_{\mathrm{p}-\mathrm{p}} \\ & \mathrm{f}_{\mathrm{O}}=10 \mathrm{~Hz}(\text { Note } 1) \end{aligned}$ | 125 | 150 | - | 125 | 150 | - | 125 | 150 | - | dB |
| Input Capacitance | $\mathrm{C}_{\text {IN }}$ |  | - | 2.6 | - | - | 2.6 | - | - | 2.6 | - | pF |
| Input Resistance Differential-Mode | $\mathrm{R}_{\text {IN }}$ |  | - | 1.1 | - | - | 1.1 | - | - | 1.1 | - | M $\Omega$ |
| Input Resistance Common-Mode | $\mathrm{R}_{\text {INCM }}$ |  | - | 11 | - | - | 11 | - | - | 11 | - | G $\Omega$ |
| Settling Time | $t_{s}$ | $\begin{aligned} & A_{V}=+1 \\ & \text { to } 0.1 \% \\ & \text { to } 0.01 \% \end{aligned}$ | - | 4.5 7.5 | - | - | 4.5 7.5 | - | - | 4.5 7.5 | - | $\mu \mathrm{S}$ |

## NOTES:

1. Guaranteed but not $100 \%$ tested.
2. Sample tested.
3. Guaranteed by CMR test.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V},-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq 125^{\circ} \mathrm{C}$ for OP-471A, unless otherwise noted.

|  |  |  | OPMBOL |  |
| :--- | :--- | :--- | :--- | :--- |
| PARAMETER |  |  |  |  |

## NOTE:

1. Guaranteed by CMR test.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V},-25^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ for OP- $471 \mathrm{E} / \mathrm{F},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ for $\mathrm{OP}-471 \mathrm{G}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-471E |  |  | OP-471F |  |  | OP-471G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Input Offset Voltage | $\mathrm{v}_{\text {OS }}$ |  | - | 0.3 | 1.1 | - | 0.6 | 2.0 | - | 1.2 | 2.5 | mv |
| Average Input Offset Voltage Drift | $\mathrm{TCV}_{\text {Os }}$ |  | - | 1 | 4 | - | 2 | 7 | - | 4 | - | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current | Ios | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 5 | 20 | - | 8 | 40 | - | 20 | 50 | nA |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ | $V_{C M}=0 \mathrm{~V}$ | - | 13 | 50 | - | 25 | 70 | - | 40 | 75 | nA |
| Large-Signal Voltage Gain | $A_{\text {vo }}$ | $\begin{gathered} \mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \\ \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \\ \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \end{gathered}$ | $\begin{aligned} & 375 \\ & 250 \end{aligned}$ | $\begin{aligned} & 600 \\ & 400 \end{aligned}$ | - | $\begin{array}{r} 200 \\ 125 \end{array}$ | $\begin{aligned} & 400 \\ & 200 \end{aligned}$ | - | $\begin{array}{r} 200 \\ 125 \end{array}$ | $\begin{aligned} & 400 \\ & 200 \end{aligned}$ | - | $\mathrm{V} / \mathrm{mV}$ |
| Input Voltage Range | IVR | (Note 1) | $\pm 11$ | $\pm 12$ | - | $\pm 11$ | $\pm 12$ | - | $\pm 11$ | $\pm 12$ | - | v |
| Output Voltage Swing | $\mathrm{V}_{\mathrm{O}}$ | $\mathrm{R}_{\mathrm{L}} \geq 2 \mathrm{k} \Omega$ | $\pm 12$ | $\pm 13$ | - | $\pm 12$ | $\pm 13$ | - | $\pm 12$ | $\pm 13$ | - | V |
| Common-Mode Rejection | CMR | $\mathrm{V}_{\mathrm{CM}}= \pm 11 \mathrm{~V}$ | 100 | 115 | - | 90 | 110 | - | 90 | 110 | - | dB |
| Power Supply Rejection Ratio | PSRR | $\mathrm{V}_{S}= \pm 4.5 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | 3.2 | 10 | - | 18 | 31.6 | - | 18 | 31.6 | $\mu \mathrm{V} / \mathrm{V}$ |
| Supply Current (All Amplifiers) | $\mathrm{I}_{\mathrm{SY}}$ | No Load | - | 9.3 | 11 | - | 9.3 | 11 | - | 9.3 | 11 | mA |

## NOTE:

1. Guaranteed by CMR test. Quad Operational Amplifier

## FEATURES

- Single/Dual Supply Operation $\qquad$ +1.6 V to +36 V $\pm 0.8 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$
- True Single-Supply Operation; Input and Output Voltage Ranges Include Ground
- Low Supply Current $\qquad$ $80 \mu \mathrm{~A}$ Max
- High Output Drive 5mA Min
- Low Offset Voltage 0.5mA Max
- High Open-Loop Gain 700V/mV Min
- Outstanding PSRR
$\qquad$ $5.6 \mu \mathrm{~V} / \mathrm{V}$ Min
- Industry Standard Quad Pinouts
- Available in Die Form


## ORDERING INFORMATION ${ }^{\dagger}$

| $\begin{gathered} T_{A}=+25^{\circ} \mathrm{C} \\ \mathrm{~V}_{\text {OS }} \mathrm{MAX} \\ (\mathrm{mV}) \\ \hline \end{gathered}$ | PACKAGE |  |  | OPERATING TEMPERATURE RANGE |
| :---: | :---: | :---: | :---: | :---: |
|  | $\begin{aligned} & \text { CERDIP } \\ & \text { 14-PIN } \end{aligned}$ | PLASTIC | LCC <br> 28-CONTACT |  |
| 0.5 | OP490AY* | - | OP490ATC/883 | MIL |
| 0.5 | OP490EY | - | - | IND |
| 0.75 | OP490FY | - | - | IND |
| 1.0 | - | OP490GP | - | XIND |
| 1.0 | - | OP490GS ${ }^{\text {t }}$ | - | XIND |

* For devices processed in total compliance to MIL-STD-883, add /883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.
tt For availability and burn-in information on SO and PLCC packages, contact your local sales office.


## PIN CONNECTIONS


14-PIN HERMETIC DIP
(Y-Suffix)
14-PIN PLASTIC DIP
(P-Suffix)

16-PIN SOL (S-Suffix)

28-PIN LCC
(TC-Suffix)

## GENERAL DESCRIPTION

The OP-490 is a high-performance micropower quad op amp that operates from a single supply of +1.6 V to +36 V or from dual supplies of $\pm 0.8 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$. Input voltage range includes the negative rail allowing the OP-490 to accommodate input signals down to ground in single-supply operation. The OP-490's output swing also includes ground when operating from a single supply, enabling "zero-in, zero-out" operation.

Continued
SIMPLIFIED SCHEMATIC (One of four amplifiers is shown.)


This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

## GENERAL DESCRIPTION Continued

The quad OP-490 draws less than $20 \mu \mathrm{~A}$ of quiescent supply current per amplifier, but each amplifier is able to deliver over 5 mA of output current to a load. Input offset voltage is under 0.5 mV with offset drift below $5 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ over the military temperature range. Gain exceeds over 700,000 and CMR is better than 100 dB . A PSRR of under $5.6 \mu \mathrm{~V} / \mathrm{V}$ minimizes offset voltage changes experienced in battery powered systems.
The quad OP-490 combines high performance with the space and cost savings of quad amplifiers. The minimal voltage and current requirements of the OP-490 makes it ideal for battery and solar powered applications, such as portable instruments and remote sensors.

## ABSOLUTE MAXIMUM RATINGS (Note 2)

Supply Voltage $\qquad$ $\pm 18 \mathrm{~V}$
Differential Input Voltage ............. [(V-) - 20V] to [(V+) + 20V] Common-Mode Input Voltage ...... [(V-) - 20V] to [(V+) + 20V]
Output Short-Circuit Duration
..Continuous

Storage Temperature Range
TC, Y, P Package ....................................... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ Operating Temperature Range
OP-490A .................................................... $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$

OP-490E, OP-490F ....................................... $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
OP-490G ....................................................... $40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Junction Temperature (Tj) ........................... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature Range (Soldering, 60 sec ) ........... $+300^{\circ} \mathrm{C}$

| PACKAGE TYPE | $\Theta_{\text {IA }}($ Note 1) | $\Theta_{\mathrm{JC}}$ | UNITS |
| :--- | :---: | :---: | :---: |
| 14-Pin Hermetic DIP (Y) | 99 | 12 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 14-Pin Plastic DIP (P) | 76 | 33 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 28-Contact LCC (TC) | 78 | 30 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $16-$ Pin SOL (S) | 92 | 27 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTES:

1. $\Theta_{\mathrm{jA}}$ is specified for worst case mounting conditions, i.e., $\Theta_{\mathrm{jA}}$ is specified for device in socket for CerDIP, P-DIP, and LCC packages; $\Theta_{j A}$ is specified for device soldered to printed circuit board for SOL package.
2. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 1.5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.


## OP490

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 1.5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted. Continued

|  |  |  | MIN ${ }_{\text {OP-490A/E }}^{\text {TYP }}$ |  |  | OP-490F |  |  | OP-490G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PARAMETER | SYMBOL | CONDITIONS |  |  |  | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Inpút Resistance Differential Mode | $\mathrm{R}_{\text {IN }}$ | $V_{S}= \pm 15 \mathrm{~V}$ | - | 30 | - | - | 30 | - | - | 30 | - | $\mathrm{M} \Omega$ |
| Input Resistance Common Mode | $\mathrm{R}_{\text {INCM }}$ | $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}$ | - | 20 | - | - | 20 | - | - | 20 | - | G $\Omega$ |
| Gain Bandwidth Product | GBWP | $A_{V}=+1$ | - | 20 | - | - | 20 | - | - | 20 | - | kHz |
| Channel Separation | CS | $\begin{aligned} & f_{\mathrm{O}}=10 \mathrm{~Hz} \\ & \mathrm{~V}_{\mathrm{O}}=20 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V} \text { (Note 2) } \end{aligned}$ | 120 | 150 | - | 120 | 150 | - | 120 | 150 | - | dB |

## NOTES:

1. Guaranteed by CMR test.
2. Guaranteed but not $100 \%$ tested.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 1.5 \mathrm{~V}$ to $\pm 15 \mathrm{~V},-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | OP-490A |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | UNITS |
| Input Offset Voltage | $\mathrm{V}_{\text {OS }}$ |  | - | 0.4 | 1.0 | mV |
| Average Input Offset Voltage Drift | $\mathrm{TCV}_{\text {OS }}$ | $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}$ | - | 2 | 5 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current | los | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | - | 1.5 | 5 | $n A$ |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ | $V_{C M}=0 \mathrm{~V}$ | - | 4.4 | 20 | nA |
| Large-Signal Voltage Gain | Avo | $\begin{aligned} V_{S} & = \pm 15 \mathrm{~V}, \mathrm{~V}_{\mathrm{O}}= \pm 10 \mathrm{~V} \\ R_{\mathrm{L}} & =100 \mathrm{k} \Omega \\ R_{\mathrm{L}} & =10 \mathrm{k} \Omega \\ R_{\mathrm{L}} & =2 \mathrm{k} \Omega \end{aligned}$ | $\begin{array}{r} 225 \\ 125 \\ 50 \\ \hline \end{array}$ | $\begin{aligned} & 400 \\ & 240 \\ & 110 \end{aligned}$ | - | V/mV |
|  |  | $\begin{gathered} \mathrm{V}_{+}=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V}, \\ 1 \mathrm{~V}<\mathrm{V}_{\mathrm{O}}<4 \mathrm{~V} \\ \mathrm{R}_{\mathrm{L}}=100 \mathrm{k} \Omega \\ \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \end{gathered}$ | $\begin{array}{r} 100 \\ 50 \end{array}$ | $\begin{aligned} & 200 \\ & 110 \end{aligned}$ | - |  |
| Input Voltage Range | IVR | $\begin{aligned} & V_{+}=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V}(\text { Note } 1) \end{aligned}$ | $\begin{array}{r} 0 / 3.5 \\ -15 / 13.5 \end{array}$ | - | - | V |
| Output Voltage Swing | $\mathrm{V}_{0}$ | $\begin{aligned} \mathrm{V}_{\mathrm{S}} & = \pm 15 \mathrm{~V} \\ \mathrm{R}_{\mathrm{L}} & =10 \mathrm{k} \Omega \\ R_{\mathrm{L}} & =2 \mathrm{k} \Omega \end{aligned}$ | $\begin{aligned} & \pm 13 \\ & \pm 10 \end{aligned}$ | $\begin{array}{r}  \pm 13.7 \\ \pm 11 \end{array}$ | - | V |
|  | $\mathrm{V}_{\mathrm{OH}}$ | $\begin{aligned} & V_{+}=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V} \\ & R_{\mathrm{L}}=2 \mathrm{k} \Omega \end{aligned}$ | 3.9 | 4.1 | - | V |
|  | $\mathrm{V}_{\mathrm{OL}}$ | $\begin{gathered} \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V} \\ R_{\mathrm{L}}=10 \mathrm{k} \Omega \end{gathered}$ | - | 100 | 500 | $\mu \mathrm{V}$ |
| Common-Mode Rejection | CMR | $\begin{aligned} & V_{+}=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V}, 0 \mathrm{~V}<\mathrm{V}_{\mathrm{CM}}<3.5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V},-15 \mathrm{~V}<\mathrm{V}_{\mathrm{CM}}<13.5 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 85 \\ & 95 \end{aligned}$ | $\begin{aligned} & 105 \\ & 115 \end{aligned}$ | - | dB |
| Power Supply Rejection Ratio | PSRR | - | - | 3.2 | 10 | $\mu \mathrm{V} / \mathrm{V}$ |
| Supply Current <br> (All Amplifiers) | Isy | $\begin{aligned} & V_{S}= \pm 1.5 \mathrm{~V} \\ & V_{S}= \pm 15 \mathrm{~V} \end{aligned} \quad \text { No Load }$ | - | 70 90 | $\begin{aligned} & 100 \\ & 120 \\ & \hline \end{aligned}$ | $\mu \mathrm{A}$ |

## NOTE:

1. Guaranteed by CMR test.

ELECTRICAL CHARACTERISTICS
at $V_{S}= \pm 1.5 \mathrm{~V}$ to $\pm 15 \mathrm{~V},-25^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ for $\mathrm{OP}-490 \mathrm{E} / \mathrm{F},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ for OP-490G, unless otherwise noted.


## NOTE:

1. Guaranteed by CMR test.

## FEATURES

Low Offset Voltage: $50 \mu \mathrm{~V}$ max
Low Offset Voltage Drift: $0.5 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ max
Very Low Bias Current
$+25^{\circ} \mathrm{C}: 100 \mathrm{pA}$ max
$-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ : 450 pA max
Very High Open-Loop Gain: $\mathbf{2 0 0 0}$ V/mV min Low Supply Current (per Amplifier): $\mathbf{6 2 5} \mu \mathrm{A}$ max
Operates from $\pm 2 \mathrm{~V}$ to $\pm 20 \mathrm{~V}$ Supplies
High Common-Mode Rejection: 120 dB min

## APPLICATIONS

Strain Gage and Bridge Amplifiers
High Stability Thermocouple Amplifiers
Instrumentation Amplifiers
Photo-Current Monitors
High-Gain Linearity Amplifiers
Long-Term Integrators/Filters
Sample-and-Hold Amplifiers
Peak Detectors
Logarithmic Amplifiers
Battery-Powered Systems

## GENERAL DESCRIPTION

The OP-497 is a quad op amp with precision performance in the space saving, industry standard 16 -pin SOIC package. Its combination of exceptional precision with low power and extremely low input bias current makes the quad OP-497 useful in a wide variety of applications.
Precision performance of the OP-497 includes very low offset, under $50 \mu \mathrm{~V}$, and low drift, below $0.5 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$. Open-loop gain exceeds $2000 \mathrm{~V} / \mathrm{mV}$ insuring high linearity in every application. Errors due to common-mode signals are eliminated by the OP-497's common-mode rejection of over 120 dB . The OP-497's power supply rejection of over 120 dB minimizes offset voltage changes experienced in battery powered systems. Supply current of the OP-497 is under $625 \mu \mathrm{~A}$ per amplifier, and it can operate with supply voltages as low as $\pm 2 \mathrm{~V}$.
The OP-497 utilizes a superbeta input stage with bias current cancellation to maintain picoamp bias currents at all temperatures. This is in contrast to FET input op amps whose bias currents start in the picoamp range at $25^{\circ} \mathrm{C}$, but double for every $10^{\circ} \mathrm{C}$ rise in temperature, to reach the nanoamp range above $85^{\circ} \mathrm{C}$. Input bias current of the OP-497 is under 100 pA at $25^{\circ} \mathrm{C}$ and is under 450 pA over the military temperature range.
Combining precision, low power and low bias current, the OP-497 is ideal for a number of applications including instrumentation amplifiers, log amplifiers, photo-diode preamplifiers and long term integrators. For a single device see the OP-97, for a dual see the OP-297.

## PIN CONNECTIONS

16-Lead Wide Body SOIC
(S Suffix)


14-Lead Plastic Dip
(P Suffix)
14-Lead Ceramic Dip
(Y Suffix)



Input Bias, Offset Current vs. Temperature

## ELECTRICAL CHARACTERISTICS (@ $V_{S}= \pm 15 v, T_{A}=+25^{\circ} \mathrm{C}$ unless otherwise specifiee))



## NOTE

${ }^{1}$ Guaranteed by CMR Test.
Specifications subject to change without notice.

| Parameter | Symbol | Condition | OP-497 GBC <br> Limit | Units |
| :---: | :---: | :---: | :---: | :---: |
| Input Offset Voltage | $\mathrm{V}_{\text {OS }}$ |  | 150 | $\mu \mathrm{V}$ max |
| Input Offset Current | $\mathrm{I}_{\text {OS }}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | 150 | pA max |
| Input Bias Current | $\mathrm{I}_{\text {B }}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | 150 | pA max |
| Input Voltage Range ${ }^{1}$ | IVR |  | $\pm 13$ | $V$ min |
| Large Signal Voltage Gain | $\mathrm{A}_{\mathrm{vo}}$ | $\mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V}, \mathrm{R}_{\mathrm{L}} \leq 10 \mathrm{k} \Omega$ | 1500 | $\mathrm{V} / \mathrm{mV}$ min |
| Common-Mode Rejection | CMR | $\mathrm{V}_{\mathrm{CM}}= \pm 13 \mathrm{~V}$ | 114 | dB min |
| Power Supply Rejection | PSR | $\mathrm{V}_{\mathrm{S}}= \pm 2 \mathrm{~V}$ to $\pm 20 \mathrm{~V}$ | 114 | dB min |
| Output Voltage Swing | $\mathrm{V}_{0}$ | $\mathrm{R}_{\mathrm{L}} \leq 10 \mathrm{k} \Omega$ | $\pm 13$ | $V$ min |
|  |  | $\mathrm{R}_{\mathrm{L}} \leq 2 \mathrm{k} \Omega$ | $\pm 13$ | $V$ min |
| Supply Current per Amplifier | $\mathrm{I}_{\text {SY }}$ | No Load | 625 | $\mu \mathrm{A}$ max |

NOTE
${ }^{1}$ Guaranteed by CMR test. Electrical tests are performed at wafer probe to the limits shown. Due to variations in assembly methods and normal yield loss, yield after packaging is not guaranteed for standard product dice. Consult factory to negotiate specifications based on dice lot qualifications through sample lot assembly and testing.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

| Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 20$ V |  |
| :---: | :---: |
| Input Voltage ${ }^{2}$ | $\pm 20 \mathrm{~V}$ |
| Differential Input Voltage ${ }^{2}$ | 40 V |
| Output Short-Circuit Duration | Indefinite |
| Storage Temperature Range |  |
| Y, RC Package | $-65^{\circ} \mathrm{C}$ to $+175^{\circ} \mathrm{C}$ |
| P, S Package | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Operating Temperature Range |  |
| OP-497A, B, C (Y) | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| OP-497F, G (Y) | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| OP-497F, G (P, S) | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Junction Temperature |  |
| Y, RC Package | $-65^{\circ} \mathrm{C}$ to $+175^{\circ} \mathrm{C}$ |
| P, S Package | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
|  | $+300^{\circ} \mathrm{C}$ |


| Package Type | $\boldsymbol{\theta}_{\mathbf{J A}}{ }^{\mathbf{3}}$ | $\boldsymbol{\theta}_{\mathbf{J C}}$ | Units |
| :--- | :---: | :---: | :---: |
| 14-Pin Cerdip (Y) | 94 | 10 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 14-Pin Plastic DIP (P) | 76 | 33 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 20-Contact LCC (RC) | 78 | 33 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 16-Pin SOIC (S) | 92 | 23 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTES

${ }^{1}$ Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
${ }^{2}$ For supply voltages less than $\pm 20 \mathrm{~V}$, the absolute maximum input voltage is equal to the supply voltage.
${ }^{3} \theta_{\mathrm{JA}}$ is specified for worst case mounting conditions, i.e., $\theta_{\mathrm{JA}}$ is specified for device in socket for cerdip, P-DIP, and LCC packages; $\theta_{\mathrm{JA}}$ is specified for device soldered to printed circuit board for SOIC package.


## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| OP497AY | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 14-Pin Cerdip | $\mathrm{Q}-14$ |
| OP497BY | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 14-Pin Cerdip | $\mathrm{Q}-14$ |
| OP497CY | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 14-Pin Cerdip | $\mathrm{Q}-14$ |
| OP497BRC/883 | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 20-Contact LCC | $\mathrm{E}-20 \mathrm{~A}$ |
| OP497FY | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 14-Pin Cerdip | $\mathrm{Q}-14$ |
| OP497FP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 14-Pin Plastic DIP | $\mathrm{N}-14$ |
| OP497FS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 16-Pin SOIC | $\mathrm{R}-16$ |
| OP497GY | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 14-Pin Cerdip | $\mathrm{Q}-14$ |
| OP497GP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 14-Pin Plastic DIP | $\mathrm{N}-14$ |
| OP497GS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 16-Pin SOIC | $\mathrm{R}-16$ |

$\star$ For outline information see Package Information section.

DICE CHARACTERISTICS


Die Size $0.112 \times 0.129$ inch, 14,448 sq. mils

Channel Separation Test Circuit

## Instrumentation Amplifiers Contents

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Selection Guide-Instrumentation Amplifiers

| Category | Model | Gain Range | $\begin{aligned} & \text { Gain Error* } \\ & \pm \% \\ & \max (G=1) \end{aligned}$ | $\begin{aligned} & \text { Gain TC}{ }^{\star} \\ & \operatorname{ppm} /{ }^{\circ} \mathbf{C} \\ & \max (\mathbf{G}=1) \end{aligned}$ | Nonlinearity \% <br> $\max (G=1)$ | Input <br> Offset <br> Voltage <br> $\mu \mathrm{V}$ max | Input Offset Current nA max | Voltage <br> Noise <br> @ 1 kHz <br> nV $/ \sqrt{\mathbf{H z}}$ <br> RTI typ | Slew <br> Rate <br> Volts/ $\mu \mathrm{s}$ typ | Power <br> Supply <br> Range <br> $\pm$ Volts | Package Options ${ }^{1}$ | Temp Ranges ${ }^{2}$ | Page ${ }^{3}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| High | AD524 | 1 to 1,000 | 0.02 | 5 | 0.003 | 50 | 10 | 7 | 5 | 6 to 18 | D, E | I, M/D | 10-5 |
| Accuracy | AD620 | 1 to 10,000 | 0.02 | $-50(\mathrm{G} \leq 1000)$ | $0.004(\mathrm{G} \leq 1000)$ | 50 | 0.5 | 16.4 | 1.2 | 2.3 to 18 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | 10-11 |
|  | AD621 | 10 to 100 | 0.05 ( $\mathrm{G}=10$ or 100) | $5(\mathrm{G}=10)$ | $0.001(\mathrm{G}=10)$ | 125 | 0.5 | 17 | 1.2 | 2.3 to 18 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | 10-15 |
|  | AMP02 | 1 to 10,000 | 0.02 | $50(\mathrm{G} \leq 1000)$ | $0.006(\mathrm{G} \leq 1000)$ | 100 | 5 | 9 | 6 | 4.5 to 18 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/s | 10-35 |
|  | AD624 | 1 to 1,000 | 0.02 | 5 | $\pm 0.001$ | 25 | $\pm 10$ | 4 | 5 | 6 to 18 | D | I, M/ | 10-19 |
| Low | AD624 | 1 to 1,000 | 0.02 | 5 | $\pm 0.001$ | 25 | $\pm 10$ | 4 | 5 | 6 to 18 | D | I, M/ | 10-19 |
| Voltage | AD625 | 1 to 10,000 | 0.02 | $5(\mathrm{G} \leq 1000)$ | $0.001(\mathrm{G} \leq 256)$ | 25 | $\pm 5$ | 4 | 5 | 6 to 18 | D, N | C, I, M/ ${ }_{\text {D }}$ | 10-22 |
| Noise | AMP01 | 0.1 to 10,000 | $0.6(\mathrm{G}=1-1 \mathrm{k})$ | 10 (G $\leq 1000$ ) | 0.01 | 50 | 1 | 5 | 4.5 | 4.5 to 18 | $\mathbf{E}, \mathbf{Q}, \mathbf{R}$ | C, I, M | 10-29 |
| Resistor | AD620 | 1 to 10,000 | 0.02 | $-50(\mathrm{G} \leq 1000)$ | $0.004(\mathrm{G} \leq 1000)$ | 50 | 0.5 | 16.4 | 1.2 | 2.3 to 18 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | 10-11 |
| Programmable | AD625 | 1 to 10,000 | 0.02 | $5(\mathrm{G} \leq 1000)$ | $0.001(\mathrm{G} \leq 256)$ | 25 | $\pm 5$ | 4 | 5 | 6 to 18 | D, N | C, I, M/ ${ }_{\text {D }}$ | 10-22 |
| Gain | AMP02 | 1 to 10,000 | 0.02 | $50(\mathrm{G} \leq 1000)$ | $0.006(\mathrm{G} \leq 1000)$ | 100 | 5 | 9 | 6 | 4.5 to 18 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/s | 10-35 |
|  | AMP04 | 1 to 1,000 | 0.5 | N/A | 0.012 (typ) | 200 | 5 | N/A | 0.12 | 2.25 to 18 | N, R | $\mathbf{I}, \mathbf{M}$ | 10-39 |
| Software Prog. Gain | AD526 $\ddagger$ | 1, 2, 4, 8, 16 | 0.01 | 2 | 0.0035 | 500 | - | 30 | 6 | 4.5 to 16.5 | D, N | C, $\mathbf{I}, \mathrm{M} /{ }_{\mathbf{D}}$ | 10-8 |
| Single | AD626 ${ }^{-1}$ | 10 to 100 | 0.6 (G=10 or 100) | $30(\mathrm{G}=10)$ | 0.016 (G=10) | 2500 | N/A** | 250 | 0.22 | +2.4 to +12 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | 10-5 |
| Supply | AMP04 | 1 to 1,000 | 0.5 | N/A | 0.012 (typ) | 200 | 5 | N/A | 0.12 | +4.5 to +36 | N, R | I, M | 10-39 |
| Low | AD620 | 1 to 10,000 | 0.02 | $-50(\mathrm{G} \leq 1000)$ | $0.04(\mathrm{G} \leq 1000)$ | 50 | 0.5 | 16.4 | 1.2 | 2.3 tol8 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | 10-11 |
| Power | AD621 | 10 to 100 | 0.05 (G=10 or 100) | $5(\mathrm{G}=10)$ | $0.01(\mathrm{G}=10)$ | 50 | 0.5 | 17 | 1.2 | 2.3 to 18 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | 10-15 |
|  | AMP04 | 1 to 1,000 | 0.5 | N/A | 0.012 (typ) | 200 | 5 | N/A | 0.12 | 2.25 tol8 | $\mathbf{N}, \mathbf{R}$ | I, M | 10-39 |
|  | AD626 | 10 to 100 | 0.3 (G=10) | $30(\mathrm{G}=10)$ | 0.055 (G=10) | 250 | N/A** | 250 | 0.22 | 1.2 to 6 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | 10-25 |
| Input | AD524 | 1 to 1,000 | 0.02 | 5 | 0.003 | 50 | $\pm 10$ | 7 | 5 | 6 to 18 | D, E | I, M/ $\mathbf{D}^{\text {I }}$ | 10-5 |
| Protected | AMP02 | 1 to 10,000 | 0.02 | $50(\mathbf{G} \leq 1000)$ | $0.006(\mathrm{G} \leq 1000)$ | 100 | 5 | 9 | 6 | 4.5 to 18 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/s | 10-35 |
| Differential | AMP03 | 1 | 0.008 | 0.015 | - | 400 | - | - | 9.5 | 6 to 18 | D, H | I, M | A 4-149 |
| Amp | AD626 | 10 to 100 | 0.3 ( $\mathrm{G}=10$ ) | $30(\mathrm{G}=10)$ | 0.055 (G=10) | 250 | N/A** | 250 | 0.22 | 1.2 to 6 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | 10-25 |
|  | SSM2143 | 0.5 | 0.1 | - | - | 1200 | - | - | 10 | 6 to 18 | N, R | I | 14-28 |
| Low Input | AD620 | 1 to 10,000 | 0.02 | $-50(\mathrm{G} \leq 1000)$ | $0.004(\mathrm{G} \leq 1000)$ | 50 | 0.5 | 16.4 | 1.2 | 2.3 to 18 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | 10-11 |
| Bias | AD621 | 10 to 100 | 0.05 ( $\mathrm{G}=10$ or 100) | $5(\mathrm{G}=10)$ | $0.001(\mathrm{G}=10)$ | 50 | 0.5 | 17 | 1.2 | 2.3 tol8 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | 10-15 |
| Current | AMP05 | 0.1 to 2,000 | $0.5(\mathrm{G}=1-1 \mathrm{k})$ | $20(\mathrm{G} \leq 1000)$ | 0.001 (typ) | 1000 | 0.025 | 350 | 7.5 | 4.5 to 18 | Q | I, $\mathrm{M} / \mathrm{s}$ | A 4-165 |

*Does not include effects of external gain resistor ( $\mathbf{R g}$ ).
$\ddagger$ Digitally programmable.
TAD626 is specified differently for single and dual supply operation
$\star \star$ Resistance equals $200 \mathrm{k} \Omega$.




temperature designator will be followed by: / to indicate 883 B , ${ }_{\mathrm{J}}$ for JAN, ${ }_{\mathrm{D}}$ for SMD, and ${ }_{\mathrm{S}}$ for space level.
${ }^{3} \mathrm{~A}=$ Amplifier Reference Manual. All other entries refer to this volume.
Boldface Type: Data sheet information in this volume.

## Precision Instrumentation Amplifier

## FEATURES


Low Nonlinearity: 0.003\% (G = 1)
High CMRR: 120dB (G = 1000)
Low Offset Voltage: $50 \mu \mathrm{~V}$
Low Offset Voltage Drift: $0.5 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$
Gain Bandwidth Product: $\mathbf{2 5 M H z}$
Pin Programmable Gains of 1, 10, 100, 1000
Input Protection, Power On - Power Off
No External Components Required
Internally Compensated
MIL-STD-883B and Chips Available
16-Pin Ceramic DIP and SOIC Packages and
20-Terminal Leadless Chip Carriers Available
Available in Tape and Reel in Accordance with EIA-481A Standard
Standard Military Drawing Also Available

## PRODUCT DESCRIPTION

The AD524 is a precision monolithic instrumentation amplifier designed for data acquisition applications requiring high accuracy under worst-case operating conditions. An outstanding combination of high linearity, high common mode rejection, low offset voltage drift, and low noise makes the AD524 suitable for use in many data acquisition systems.

The AD524 has an output offset voltage drift of less than $25 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$, input offset voltage drift of less than $0.5 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}, \mathrm{CMR}$ above 90 dB at unity gain ( 120 dB at $\mathrm{G}=1000$ ) and maximum nonlinearity of $0.003 \%$ at $\mathrm{G}=1$. In addition to the outstanding dc specifications the AD524 also has a 25 MHz gain bandwidth product ( $\mathrm{G}=$ 100). To make it suitable for high speed data acquisition systems the AD524 has an output slew rate of $5 \mathrm{~V} / \mu \mathrm{s}$ and settles in $15 \mu \mathrm{~s}$ to $0.01 \%$ for gains of 1 to 100 .
As a complete amplifier the AD524 does not require any external components for fixed gains of $1,10,100$ and 1,000 . For other gain settings between 1 and 1000 only a single resistor is required. The AD524 input is fully protected for both power on and power off fault conditions.

The AD524 IC instrumentation amplifier is available in four different versions of accuracy and operating temperature range. The economical " $A$ " grade, the low drift " $B$ " grade and lower drift, higher linearity "C" grade are specified from $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. The " S " grade guarantees performance to specification over the extended temperature range $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. Devices are available in 16-pin ceramic DIP and SOIC packages and a 20-terminal leadless chip carrier.

## PRODUCT HIGHLIGHTS

1. The AD524 has guaranteed low offset voltage, offset voltage drift and low noise for precision high gain applications.
CONNECTION DIAGRAMS
Ceramic (D) and
SOIC (R) Packages



2. The AD524 is functionally complete with pin programmable gains of $1,10,100$ and 1000 , and single resistor programmable for any gain.
3. Input and output offset nulling terminals are provided for very high precision applications and to minimize offset voltage changes in gain ranging applications.
4. The AD524 is input protected for both power on and power off fault conditions.
5. The AD524 offers superior dynamic performance with a gain bandwidth product of 25 MHz , full power response of 75 kHz and a settling time of $15 \mu \mathrm{~s}$ to $0.01 \%$ of a 20 V step ( $\mathrm{G}=100$ ).
[^203]AD524-SPECIFICATIONS $\left(@ v_{S}= \pm 15 v, R_{L}=2 k \Omega\right.$ and $T_{A}=+25^{\circ} \mathrm{C}$ unless otherwise noted)


| Model | AD524A |  |  | AD524B |  |  | AD524C |  |  | AD524S |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| SENSE INPUT |  |  |  |  |  |  |  |  |  |  |  |  |  |
| $\mathbf{R}_{\text {IN }}$ |  | 20 |  |  | 20 |  |  | 20 |  |  | 20 |  | $\mathbf{k} \boldsymbol{\Omega} \pm \mathbf{2 0 \%}$ |
| $\mathrm{I}_{\mathrm{IN}}$ |  | 15 |  |  | 15 |  |  | 15 |  |  | 15 |  | $\mu \mathrm{A}$ |
| Voltage Range | $\pm 10$ |  |  | $\pm 10$ |  |  | $\pm 10$ |  |  | $\pm 10$ |  |  | V |
| Gain to Output |  | 1 |  |  | 1 |  |  | 1 |  |  | 1 |  | \% |
| REFERENCE INPUT |  |  |  |  |  |  |  |  |  |  |  |  |  |
| $\mathbf{R}_{\text {IN }}$ |  | 40 |  |  | 40 |  |  | 40 |  |  | 40 |  | $\mathbf{k} \Omega \pm \mathbf{2 0 \%}$ |
| $\mathrm{I}_{\text {IN }}$ |  | 15 |  |  | 15 |  |  | 15 |  |  | 15 |  | $\mu \mathrm{A}$ |
| Voltage Range | $\pm 10$ |  |  | $\pm 10$ |  |  | 10 |  |  | 10 |  |  | V |
| Gain to Output |  | 1 |  |  | 1 |  |  | 1 |  |  | 1 |  | \% |
| TEMPERATURERANGE |  |  |  |  |  |  |  |  |  |  |  |  |  |
| Specified Performance | -25 |  | +85 | -25 |  | +85 | -25 |  | +85 | -55 |  | $+125$ | ${ }^{\circ} \mathrm{C}$ |
| Storage | -65 |  | +150 | -65 |  | $+150$ | -65 |  | +150 | -65 |  | +150 | ${ }^{\circ} \mathrm{C}$ |
| POWER SUPPLY |  |  |  |  |  |  |  |  |  |  |  |  |  |
| Power Supply Range | $\pm 6$ | $\pm 15$ | $\pm 18$ | $\pm 6$ | $\pm 15$ | $\pm 18$ | $\pm 6$ | $\pm 15$ | $\pm 18$ | $\pm 6$ | $\pm 15$ | $\pm 18$ | V |
| Quiescent Current |  | 3.5 | 5.0 |  | 3.5 | 5.0 |  | 3.5 | 5.0 |  | 3.5 | 5.0 | mA |

## NOTES

${ }^{1}$ Does not include effects of external resistor $\mathrm{R}_{\mathrm{G}}$
${ }^{2} V_{\text {OL }}$ is the maximum differential input voltage at $\mathbf{G}=1$ for specified nonlinearity.
$V_{\text {DL }}$ at other gains $=10 \mathrm{~V} / \mathrm{G}$.
$\mathbf{V}_{\mathbf{D}}=$ Actual differential input voltage.
Example: $\mathbf{G}=10, V_{D}=0.50$
$\mathrm{V}_{\mathrm{CM}}=12 \mathrm{~V}-(10 / 2 \times 0.50 \mathrm{~V})=9.5 \mathrm{~V}$
Specifications subject to change without notice.
All min and max specifications are guaranteed. Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

Supply Voltage . . . . . . . . . . . . . . . . . . . . . $\pm 18 \mathrm{~V}$
Internal Power Dissipation . . . . . . . . . . . . . 450 mW
Input Voltage, ${ }^{2}$

Input Voltage, ${ }^{2}$
(Either Input Simultaneously) $\left|\mathbf{V}_{\mathrm{IN}}\right|+\left|\mathrm{V}_{\mathrm{S}}\right| \ldots \ldots \mathrm{C}$. . . $<36 \mathrm{~V}$
Output Short Circuit Duration . . . . . . . . . . . Indefinite
Storage Temperature Range
(R)
$-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
(D, E)
$-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

Operating Temperature Range

```
AD524A/B/C
\(-25^{\circ} \mathrm{C}\) to \(+85^{\circ} \mathrm{C}\)
AD524S . . . . . . . . . . . . . . . . . . \(-55^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\)
Lead Temperature Range (Soldering 60 seconds) . . \(+300^{\circ} \mathrm{C}\)
```



## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ Max input voltage specification refers to maximum voltage to which either input terminal may be raised with or without device power applied. For example, with $\pm 18$ volt supplies max $V_{\text {IN }}$ is $\pm 18$ volts, with zero supply voltage max $V_{\text {IN }}$ is $\pm 36$ volts.

## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD524AD | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 16-Pin Ceramic DIP | D-16 |
| AD524AE | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 20-Pin Leadless Chip Carrier | E-20A |
| AD524AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 16-Pin Gull-Wing SOIC | R-16 |
| AD524AR-REEL | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Tape \& Reel Packaging |  |
| AD524BD | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 16-Pin Ceramic DIP | D-16 |
| AD524BE | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 20-Pin Leadless Chip Carrier | E-20A |
| AD524CD | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 16-Pin Ceramic DIP | D-16 |
| AD524SD | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 16-Pin Ceramic DIP | D-16 |
| AD524SD/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 16-Pin Ceramic DIP | D-16 |
| AD524SE/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 20-Pin Leadless ChipCarrier | E-20A |
| AD524AChips | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Die |  |
| AD524SChips | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Die |  |

*For outline information see Package Information section.

FUNCTIONAL BLOCK DIAGRAM


FEATURES
Digitally Programmable Binary Gains from 1 to 16
Two-Chip Cascade Mode Achieves Binary Gain from 1 to 256
Gain Error:
0.01\% max, Gain $=$ 1, 2, 4 (C Grade)
0.02\% max, Gain = 8, 16 (C Grade)
$0.5 p p m /{ }^{\circ} \mathrm{C}$ Drift Over Temperature
Fast Settling Time
10V Signal Change: $0.01 \%$ in $4.5 \mu$ s (Gain $=16$ )
Gain Change: $0.01 \%$ in $5.6 \mu \mathrm{~s}$ (Gain $=16$ )
Low Nonlinearity: $\pm \mathbf{0 . 0 0 5 \%}$ FSR max (J Grade)
Excellent DC Accuracy:
Offset Voltage: 0.5 mV max (C Grade)
Offset Voltage Drift: $3 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ (C Grade)
TTL Compatible Digital Inputs
Standard Military Drawing Available

## PRODUCT DESCRIPTION

The AD526 is a single-ended, monolithic software programmable gain amplifier (SPGA) that provides gains of $1,2,4,8$ and 16. It is complete, including amplifier, resistor network and TTL-compatible latched inputs, and requires no external components.

Low gain error and low nonlinearity make the AD526 ideal for precision instrumentation applications requiring programmable gain. The small signal bandwidth is 350 kHz at a gain of 16 . In addition, the AD526 provides excellent dc precision. The FETinput stage results in a low bias current of 50 pA . A guaranteed maximum input offset voltage of 0.5 mV max ( C grade) and low gain error $(0.01 \%, G=1,2,4, \mathrm{C}$ grade) are accomplished using Analog Devices' laser trimming technology.
To provide flexibility to the system designer, the AD526 can be operated in either latched or transparent mode. The force/sense configuration preserves accuracy when the output is connected to remote or low impedance loads.
The AD526 is offered in one commercial $\left(0\right.$ to $\left.+70^{\circ} \mathrm{C}\right)$ grade, J , and three industrial grades, A, B and C, which are specified from $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. The $S$ grade is specified from $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. The military version is available processed to MIL-STD $883 \mathrm{~B}, \operatorname{Rev}$ C. The J grade is supplied in a 16 -pin plastic DIP, and the other grades are offered in a 16 -pin hermetic side-brazed ceramic DIP.

PIN CONFIGURATION


## APPLICATION HIGHLIGHTS

1. Dynamic Range Extension for ADC Systems: A single AD526 in conjunction with a 12 -bit ADC can provide 96 dB of dynamic range for ADC systems.
2. Gain Ranging Pre-Amps: The AD526 offers complete digital gain control with precise gains in binary steps from 1 to 16. Additional gains of $32,64,128$ and 256 are possible by cascading two AD526s.

[^204]


## NOTES

${ }^{1}$ Refer to Figure 35 for definitions.
FSR $=$ Full-Scale Range $=20 \mathrm{~V}$.
RTI $=$ Referred to Input.
${ }^{2}$ For outline information see Package Information section.

Specifications subject to change without notice.
Specifications shown in boldface are tested on all production units at final electrical test. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.


Figure 35. AD526 Timing

## Low Cost, Low Power Instrumentation Amplifier AD620

## FEATURES

## EASY TO USE

## Gain Set with One External Resistor <br> (Gain Range 1 to 1000) <br> Wide Power Supply Range ( $\pm 2.3 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ )

Higher Performance than Three Op Amp IA Designs
Available in 8-Pin DIP and SOIC Packaging
Low Power, 1.3 mA max Supply Current
EXCELLENT DC PERFORMANCE ("A GRADE")
$125 \mu \mathrm{~V}$ max, Input Offset Voltage ( $50 \mu \mathrm{~V}$ max "B" Grade)
$1 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ max, Input Offset Drift
2.0 nA max, Input Bias Current
$93 \mathrm{~dB} \mathbf{~ m i n}$ Common-Mode Rejection Ratio ( $\mathrm{G}=10$ )
LOW NOISE
9 nV/ $\sqrt{\mathrm{Hz}}$, @ 1 kHz, Input Voltage Noise
$0.28 \mu \mathrm{~V}$ p-p Noise ( 0.1 Hz to 10 Hz )

## EXCELLENT AC SPECIFICATIONS

120 kHz Bandwidth ( $\mathbf{G}=100$ )
$15 \mu \mathrm{~s}$ Settling Time to $0.01 \%$
APPLICATIONS
Weigh Scales
ECG and Medical Instrumentation
Transducer Interface
Data Acquisition Systems
Industrial Process Controls
Battery Powered and Portable Equipment

## PRODUCT DESCRIPTION

The AD620 is a low cost, high accuracy instrumentation amplifier which requires only one external resistor to set gains of 1 to 1000. Furthermore, the AD620 features 8 -pin SOIC and DIP packaging that is smaller than discrete designs, and offers lower


Three Op Amp IA Designs vs. AD620

## CONNECTION DIAGRAM

8-Pin Plastic Mini-DIP (N), Cerdip (Q) and SOIC (R) Packages

power (only 1.3 mA max supply current), making it a good fit for battery powered, portable (or remote) applications.
The AD620, with its high accuracy of 40 ppm maximum nonlinearity, low offset voltage of $50 \mu \mathrm{~V}$ max and offset drift of $0.6 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ max, is ideal for use in precision data acquisition systems, such as weigh scales and transducer interfaces. Furthermore, the low noise, low input bias current, and low power of the AD620 make it well suited for medical applications such as ECG and noninvasive blood pressure monitors.

The low input bias current of 1.0 nA max is made possible with the use of Superßeta processing in the input stage. The AD620 works well as a preamplifier due to its low input voltage noise of $9 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ at $1 \mathrm{kHz}, 0.28 \mu \mathrm{~V}$ p-p in the 0.1 Hz to 10 Hz band, $0.1 \mathrm{pA} / \sqrt{\mathrm{Hz}}$ input current noise. Also, the AD620 is well suited for multiplexed applications with its settling time of $15 \mu \mathrm{~s}$ to $0.01 \%$ and its cost is low enough to enable designs with one in amp per channel.


Total Voltage Noise vs. Source Resistance

This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

# ADG2O - SPEGFEGATONS (typical @ $+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}$, and $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ unless otherwise noted) 




## NOTES

${ }^{1}$ Does not include effects of external resistor $\mathbf{R}_{\mathbf{G}}$.
${ }^{2}$ One input grounded. $\mathrm{G}=1$.
${ }^{3}$ This is defined as the same supply range which is used to specify PSR.
${ }^{4}$ See Analog Devices military data sheet for 883B tested specifications.
Specifications subject to change without notice.

ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

| Supply Voltage | V |
| :---: | :---: |
| Internal Power Dissipation ${ }^{2}$ | 650 mW |
| Input Voltage (Common Mode) | $\pm \mathrm{V}_{\text {S }}$ |
| Differential Input Voltage | $\pm 25 \mathrm{~V}$ |
| Output Short Circuit Duration | Indefinite |
| Storage Temperature Range (Q) | to $+150^{\circ} \mathrm{C}$ |
| Storage Temperature Range ( $\mathrm{N}, \mathrm{R}$ ) | $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Operating Temperature Range |  |
| AD620 (A, B) | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| AD620 (S) | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |

## Lead Temperature Range

(Soldering 10 seconds) . . . . . . . . . . . . . . . . . . . . . $300^{\circ} \mathrm{C}$

## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability
${ }^{2}$ Specification is for device in free air: 8-Pin Plastic Package: $\theta_{\mathrm{JA}}=95^{\circ} \mathrm{C} / \mathrm{W}$ att
8-Pin Cerdip Package: $\theta_{\mathrm{JA}}=110^{\circ} \mathrm{C} / \mathrm{W}$ att
8 -Pin SOIC Package: $\theta_{\mathrm{JA}}=155^{\circ} \mathrm{C} / \mathrm{W}$ att

ORDERING GUIDE

| Model | Temperature Range | Package Option* |
| :--- | :--- | :--- |
| AD620AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| AD620BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| AD620AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-8$ |
| AD620BR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-8$ |
| AD620AChips | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Die Form |
| AD620SQ $/ 883 \mathrm{~B}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Q-8 |

${ }^{*} \mathrm{~N}=$ Plastic DIP; $\mathrm{Q}=$ Cerdip; $\mathrm{R}=$ SOIC.

## ESD SUSCEPTIBILITY

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 volts, which readily accumulate on the human body and on test equipment, can discharge without detection. Although the AD620 features proprietary ESD protection circuitry, permanent damage may still occur on these devices if they are subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid any performance degradation or loss of functionality.

## METALIZATION PHOTOGRAPH

Dimensions shown in inches and (mm).
Contact factory for latest dimensions.


# Low Drift, Low Power Instrumentation Amplifier 

FEATURES

## EASY TO USE

Pin-Strappable Gains of 10 \& 100
All Errors Specified for Total System Performance
Higher Performance than Discrete In-Amp Designs
Available in 8-Pin DIP and SOIC
Low Power, 1.3 mA max Supply Current
Wide Power Supply Range ( $\pm \mathbf{2 . 3} \mathrm{V}$ to $\pm 18 \mathrm{~V}$ )
EXCELLENT DC PERFORMANCE
0.15\% max, Total Gain Error
$\pm 5 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$, Total Gain Drift
$125 \mu \mathrm{~V}$ max, Total Offset Voltage
$1.0 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ max, Offset Voltage Drift
LOW NOISE
9 nV/ $\sqrt{\mathrm{Hz}}$, @ 1 kHz, Input Voltage Noise
$0.28 \mu \mathrm{~V}$ p-p Noise ( 0.1 Hz to 10 Hz )
EXCELLENT AC SPECIFICATIONS
800 kHz Bandwidth ( $G=10$ ), $200 \mathrm{kHz}(G=100)$
$12 \mu \mathrm{~s}$ Settling Time to 0.01\%
APPLICATIONS

## Weigh Scales

Transducer Interface \& Data Acquisition Systems Industrial Process Controls
Battery Powered and Portable Equipment

## PRODUCT DESCRIPTION

The AD621 is an easy to use, low cost, low power, high accuracy instrumentation amplifier which is ideally suited for a wide range of applications. Its unique combination of high performance, small size and low power, outperforms discrete in amp implementations. High functionality, low gain errors and low gain drift errors are achieved by the use of internal gain setting resistors. Fixed gains of 10 and 100 can be easily set via external pin strapping. The AD621 is fully specified as a total system, therefore, simplifying the design process.


Three Op Amp IA Designs vs. AD621

CONNECTION DIAGRAM
8-Pin Plastic Mini-DIP (N), Cerdip (Q) and SOIC (R) Packages


For portable or remote applications, where power dissipation, size and weight are critical, the AD621 features a very low supply current of 1.3 mA max and is packaged in a compact 8 -pin SOIC, 8-pin plastic DIP or 8-pin cerdip. The AD621 also excels in applications requiring high total accuracy, such as precision data acquisition systems used in weigh scales and transducer interface circuits. Low maximum error specifications including nonlinearity of 10 ppm , gain drift of $5 \mathrm{ppm} /{ }^{\circ} \mathrm{C}, 50 \mu \mathrm{~V}$ offset voltage and $0.6 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ offset drift (" B " grade), make possible total system performance at a lower cost than has been previously achieved with discrete designs or with other monolithic instrumentation amplifiers.
When operating from high source impedances, as in ECG and blood pressure monitors, the AD621 features the ideal combination of low noise and low input bias currents. Voltage noise is specified as $9 \mathrm{nV} \sqrt{\mathrm{Hz}}$ at 1 kHz and $0.28 \mu \mathrm{~V}$ p-p from 0.1 Hz to 10 Hz . Input current noise is also extremely low at $0.1 \mathrm{pA} / \sqrt{\mathrm{Hz}}$. The AD621 outperforms FET input devices with an input bias current specification of 1.5 nA max over the full industrial temperature range.


Total Voltage Noise vs. Source Resistance

## AD621 - SPECIFICATIONS

Gain $=10$ (typical $@+25 c^{c}, V_{s}= \pm 15$, , ant $R_{1}=2 \mathrm{k} \Omega$ uness othememse nteer)


[^205]Gain $=100$ (typical @ $+25^{\circ}, v_{S}= \pm 15 v$, and $R_{L}=2 \mathrm{~K} \Omega$ unless otherwise noted)


[^206]ABSOLUTE MAXIMUM RATINGS ${ }^{\mathbf{1}}$

| Supply Voltage | V |
| :---: | :---: |
| Internal Power Dissipation ${ }^{2}$ | 650 mW |
| Input Voltage | $\pm \mathrm{V}_{\text {S }}$ |
| Differential Input Voltage | $\pm 25 \mathrm{~V}$ |
| Output Short Circuit Duration | Indefinite |
| Storage Temperature Range (Q) | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Storage Temperature Range ( $\mathrm{N}, \mathrm{R}$ ) | $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Operating Temperature Range |  |
| AD621A, B | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| AD621S ${ }^{3}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |

Lead Temperature Range
(Soldering 10 seconds) . . . . . . . . . . . . . . . . . . . . $+300^{\circ} \mathrm{C}$

## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ Specification is for device in free air:
8 -Pin Plastic DIP Package: $\theta_{\mathrm{JA}}=95^{\circ} \mathrm{C} /$ Watt
8-Pin Cerdip Package: $\theta_{J A}=110^{\circ} \mathrm{C} /$ Watt
8-Pin SOIC Package: $\theta_{\mathrm{JA}}=155^{\circ} \mathrm{C} / \mathrm{W}$ att
${ }^{3}$ See Analog Devices' military data sheet for 883 B specifications.

## ESD SUSCEPTIBILITY

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 volts, which readily accumulate on the human body and on test equipment, can discharge without detection. Although the AD621 features proprietary ESD protection circuitry, permanent damage may still occur on these devices if they are subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid any performance degradation or loss of functionality.

ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD621AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | $\mathrm{N}-8$ |
| AD621BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | $\mathrm{N}-8$ |
| AD621AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | $\mathrm{R}-8$ |
| AD621BR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic SOIC | $\mathrm{R}-8$ |
| AD621SQ $/ 883 \mathrm{~B}^{2}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8 -Pin Cerdip | $\mathrm{Q}-8$ |
| AD621ACHIPS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Die |  |

## NOTES

${ }^{1}$ For outline information see Package Information section.
${ }^{2}$ See Analog Devices' military data sheet for 883 B specifications.

## METALIZATION PHOTOGRAPH

Dimensions shown in inches and (mm)
Contact factory for latest dimensions


## FEATURES

Low Noise: $0.2 \mu \mathrm{~V}$ p-p 0.1 Hz to $\mathbf{1 0 H z}$
Low Gain TC: 5ppm max (G = 1)
Low Nonlinearity: 0.001\% max (G = 1 to 200)
High CMRR: 130dB min (G = 500 to 1000)
Low Input Offset Voltage: $\mathbf{2 5 \mu} \boldsymbol{\mathrm { V }}$, max
Low Input Offset Voltage Drift: $0.25 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ max
Gain Bandwidth Product: $\mathbf{2 5 M H z}$
Pin Programmable Gains of 1, 100, 200, 500, 1000
No External Components Required
Internally Compensated

## CONNECTION DIAGRAM



FOR GAIN OF 1000 SHORT RG, TO PIN 12 AND PINS 11 AND 13 TO $\mathrm{RG}_{2}$

## PRODUCT DESCRIPTION

The AD624 is a high precision, low noise, instrumentation amplifier designed primarily for use with low level transducers, including load cells, strain gauges and pressure transducers. An outstanding combination of low noise, high gain accuracy, low gain temperature coefficient and high linearity make the AD624 ideal for use in high resolution data acquisition systems.
The AD624C has an input offset voltage drift of less than $0.25 \mu \mathrm{~V} /$ ${ }^{\circ} \mathrm{C}$, output offset voltage drift of less than $10 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}, \mathrm{CMRR}$ above 80 dB at unity gain ( 130 dB at $\mathrm{G}=500$ ) and a maximum nonlinearity of $0.001 \%$ at $G=1$. In addition to these outstanding dc specifications, the AD624 exhibits superior ac performance as well. A 25 MHz gain bandwidth product, $5 \mathrm{~V} / \mu \mathrm{s}$ slew rate and $15 \mu \mathrm{~s}$ settling time permit the use of the AD624 in high speed data acquisition applications.

The AD624 does not need any external components for pretrimmed gains of $1,100,200,500$ and 1000 . Additional gains such as 250 and 333 can be programmed within one percent accuracy with external jumpers. A single external resistor can also be used to set the 624's gain to any value in the range of 1 to 10,000 .

## PRODUCT HIGHLIGHTS

1. The AD624 offers outstanding noise performance. Input noise is typically less than $4 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ at 1 kHz .
2. The AD624 is a functionally complete instrumentation amplifier. Pin programmable gains of $1,100,200,500$ and 1000 are provided on the chip. Other gains are achieved through the use of a single external resistor.
3. The offset voltage, offset voltage drift, gain accuracy and gain temperature coefficients are guaranteed for all pre-trimmed gains.
4. The AD624 provides totally independent input and output offset nulling terminals for high precision applications. This minimizes the effect of offset voltage in gain ranging applications.
5. A sense terminal is provided to enable the user to minimize the errors induced through long leads. A reference terminal is also provided to permit level shifting at the output.



NOTES
${ }^{1} \mathrm{~V}_{\mathrm{DL}}$ is the maximum differential input voltage at $\mathrm{G}=1$ for specified nonlinearity. $\mathrm{V}_{\mathrm{DL}}$ at other gains $=10 \mathrm{~V} / \mathrm{G} . \mathrm{V}_{\mathrm{D}}=$ actual differential input voltage. Example: $\mathrm{G}=10, \mathrm{~V}_{\mathrm{D}}=0.50$.
$\mathrm{V}_{\mathrm{CM}}=12 \mathrm{~V}-(10 / 2 \times 0.50 \mathrm{~V})=9.5 \mathrm{~V}$.
${ }^{2}$ For outline information see Package Information section.
Specifications subject to change without notice.
Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.

## ABSOLUTE MAXIMUM RATINGS*



FUNCTIONAL BLOCK DIAGRAM


## METALIZATION PHOTOGRAPH

Contact factory for latest dimensions.
Dimensions shown in inches and ( mm ).


FEATURES
User Programmable Gains of 1 to $\mathbf{1 0 , 0 0 0}$
Low Gain Error: 0.02\% max
Low Gain TC: 5ppm/²C max
Low Nonlinearity: 0.001\% max
Low Offset Voltage: $\mathbf{2 5 \mu} \mathbf{V}$
Low Noise $\mathbf{4 n V} / \sqrt{\mathrm{Hz}}$ (at $\mathbf{1 k H z}$ ) RTI
Gain Bandwidth Product: 25MHz
16-Pin Ceramic or Plastic DIP Package, 20-Pin LCC Package
Standard Military Drawing Available
MIL-Standard Parts Available
Low Cost

## PRODUCT DESCRIPTION

The AD625 is a precision instrumentation amplifier specifically designed to fulfill two major areas of application:

1) Circuits requiring nonstandard gains (i.e., gains not easily achievable with devices such as the AD524 and AD624).
2) Circuits requiring a low cost, precision software programmable gain amplifier.
For low noise, high CMRR, and low drift the AD625JN is the most cost effective instrumentation amplifier solution available. An additional three resistors allow the user to set any gain from 1 to 10,000 . The error contribution of the AD625JN is less than $0.05 \%$ gain error and under $5 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ gain TC; performance limitations are primarily determined by the external resistors. Common-mode rejection is independent of the feedback resistor matching.

A software programmable gain amplifier (SPGA) can be configured with the addition of a CMOS multiplexer (or other switch network), and a suitable resistor network. Because the ON resistance of the switches is removed from the signal path, an AD625 based SPGA will deliver 12 -bit precision, and can be programmed for any set of gains between 1 and 10,000 , with completely user selected gain steps.

For the highest precision, the AD625C offers an input offset voltage drift of less than $0.25 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$, output offset drift below $15 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$, and a maximum nonlinearity of $0.001 \%$ at $\mathrm{G}=1$. All grades exhibit excellent ac performance; a 25 MHz gain bandwidth product, $5 \mathrm{~V} / \mu \mathrm{s}$ slew rate and $15 \mu$ s settling time.

The AD625 is available in three accuracy grades (A, B, C) for industrial $\left(-40^{\circ} \mathrm{C}\right.$ to $\left.+85^{\circ} \mathrm{C}\right)$ temperature range, two grades ( J , K ) for commercial ( 0 to $+70^{\circ} \mathrm{C}$ ) temperature range, and one ( S ) grade rated over the extended ( $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ ) temperature range.

## CONNECTION DIAGRAMS

Ceramic DIP (D) and Plastic DIP (N) Packages


Leadless Chip Carrier (E) Package


## PRODUCT HIGHLIGHTS

1. The AD625 affords up to $\mathbf{1 6}$-bit precision for user selected fixed gains from 1 to $\mathbf{1 0 , 0 0 0}$. Any gain in this range can be programmed by 3 external resistors.
2. A 12 -bit software programmable gain amplifier can be configured using the AD625, a CMOS multiplexer and a resistor network. Unlike previous instrumentation amplifier designs, the ON resistance of a CMOS switch does not affect the gain accuracy.
3. The gain accuracy and gain temperature coefficient of the amplifier circuit are primarily dependent on the user selected external resistors.
4. The AD625 provides totally independent input and output offset nulling terminals for high precision applications. This minimizes the effects of offset voltage in gain-ranging applications.
5. The proprietary design of the AD625 provides input voltage noise of $4 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ at 1 kHz .
6. External resistor matching is not required to maintain high common-mode rejection.

This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.



## NOTES

${ }^{1}$ Gain Error and Gain TC are for the AD625 only. Resistor network errors will add to the specified errors.
${ }^{2} V_{D L}$ is the maximum differential input voltage at $G=1$ for specified nonlinearity.
$V_{D L}$ at other gains $=10 \mathrm{~V} / \mathrm{G}$.
$\mathbf{V}_{\mathbf{D}}=$ actual differential input voltage.
Example: $G=10, V_{D}=0.50$
$\mathrm{V}_{\mathrm{CM}}=12 \mathrm{~V}-(10 / 2 \times 0.50 \mathrm{~V})=9.5 \mathrm{~V}$.
Specifications subject to change without notice.
All min and max specifications are guaranteed. Specifications shown in boldface are tested on all production
units at final electrical test. Results from those tests are used to calculate outgoing quality levels.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

Supply Voltage . . . . . . . . . . . . . . . . . . . . . $\pm 18 \mathrm{~V}$ Internal Power Dissipation . . . . . . . . . . . . . . 450mW
Input Voltage . . . . . . . . . . . . . . . . . . . . . . . $\pm \mathrm{V}_{\mathrm{S}}$
Differential Input Voltage . . . . . . . . . . . . . . . . . $\pm \mathrm{V}_{\mathrm{S}}$
Output Short Circuit Duration . . . . . . . . . . . Indefinite
Storage Temperature Range (D, E) . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Operating Temperature Range
AD625J/K . . . . . . . . . . . . . . . . . . 0 to $+70^{\circ} \mathrm{C}$
AD625A/B/C . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
AD625S . .... . . . . . . . . .

AD625S . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Lead Temperature Range
(Soldering, 60 seconds) . . . . . . . . . . . . . . . $+300^{\circ} \mathrm{C}$

## NOTE

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD625AD | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 16-Pin Ceramic DIP | D-16 |
| AD625BD | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 16-Pin Ceramic DIP | D-16 |
| AD625CD | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 16-Pin Ceramic DIP | D-16 |
| AD625SD | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 16-Pin Ceramic DIP | D-16 |
| AD625SD/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 16-Pin Ceramic DIP | D-16 |
| AD625SE/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 20-Pin Leadless Chip Carrier | E-20A |
| AD625JN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 16-Pin Plastic DIP | N-16 |
| AD625KN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 16-Pin Plastic DIP | N-16 |
| AD625AChips | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Die |  |
| AD625SChips | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Die |  |
| 5962-8771901EA | Standard Military Drawing Available |  |  |

*For outline information see Package Information section.

## FUNCTIONAL BLOCK DIAGRAM <br> ("N"AND "D" PACKAGE PINOUT)



## FEATURES

Pin Selectable Gains of 10 and 100
True Single Supply Operation
Single Supply Range of +2.4 V to +10 V
Dual Suppy Range of $\pm 1.2 \mathrm{~V}$ to $\pm 6 \mathrm{~V}$
Wide Output Voltage Range of $\mathbf{3 0} \mathbf{~ m V}$ to 4.7 V
Optional Low-Pass Filtering
Excellent DC Performance
Low Input Offset Voltage: $\mathbf{5 0 0} \mu \mathrm{V}$ max
Large Common-Mode Range: 0 V to +54 V
Low Power: $1.2 \mathrm{~mW}\left(\mathrm{~V}_{\mathrm{s}}=+5 \mathrm{~V}\right)$
Good CMR of $\mathbf{9 0} \mathbf{~ d B}$ typ

## AC Performance

Fast Settling Time: $24 \mu \mathrm{~s}$ (0.01\%)
Includes Input Protection
Series Resistive Inputs ( $\mathrm{R}_{\mathbf{I N}}=200 \mathrm{k} \Omega$ )
RFI Filters Included
Allows 50 V Continuous Overload

## APPLICATIONS

## Current Sensing

Interface for Pressure Transducers, Position Indicators, Strain Gages, and Other Low Level Signal Sources

## PRODUCT DESCRIPTION

The AD626 is a low cost, true single supply differential amplifier designed for amplifying and low-pass filtering small differential voltages from sources having a large common-mode voltage.
The AD626 can operate from either a single supply of +2.4 V to +10 V , or dual supplies of $\pm 1.2 \mathrm{~V}$ to $\pm 6 \mathrm{~V}$. The input common-mode range of this amplifier is equal to $6\left(+V_{S}\right.$ -1 V ) which provides a +24 V CMR while operating from


Common-Mode Rejection vs. Frequency

## CONNECTION DIAGRAM

8-Pin Plastic Mini-DIP (N) and SOIC (R) Packages

$\mathrm{a}+5 \mathrm{~V}$ supply. Furthermore, the AD626 features a CMR of 90 dB typ.
The amplifier's inputs are protected against continuous overload of up to 50 V , and RFI filters are included in the attenuator network. The output range is +0.03 V to +4.9 V using $\mathrm{a}+5 \mathrm{~V}$ supply. The amplifier provides a preset gain of 10 , but gains between 10 to 100 can be easily configured with an external resistor. Furthermore, a gain of 100 is available by connecting the $\mathrm{G}=100$ pin to analog ground. The AD626 also offers low- pass filter capability by connecting a capacitor between the filter pin and analog ground.
The AD626A and AD626B operate over the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. The AD626 is available in two 8 -pin packages: a plastic mini-DIP and SOIC.


Input Common-Mode Range vs. Supply

This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

AD626-SPECIFICATIONS
SINGLESUPPLY (@+V$V_{S}=+5 V$ and $\left.T_{A}=+25^{\circ} \mathrm{C}\right)$


## NOTES

${ }^{1}$ At temperatures above $+25^{\circ} \mathrm{C},-\mathrm{CMV}$ degrades at the rate of $12 \mathrm{mV} /{ }^{\circ} \mathrm{C}$; i.e., @ $+25^{\circ} \mathrm{C} \mathrm{CMV}=-2 \mathrm{~V}, @+85^{\circ} \mathrm{C} \mathrm{CMV}=-1.28 \mathrm{~V}$.
Specifications subject to change without notice.

DUAL SUPPLY (@ $\left.+\mathrm{V}_{\mathrm{s}}= \pm 5 \mathrm{Vand} \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right)$


ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

| Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . +36 V |  |
| :---: | :---: |
|  |  |
| Peak Input Voltage |  |
| Maximum Reversed Supply Voltage Limit . . . . . . . . -34 V |  |
| Output Short Circuit Duration . . . . . . . . . . . . . . . Indefinite |  |
| Storage Temperature Range (N, R) . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  |
| Operating Temperature Range |  |
| AD626A/B | to $+85^{\circ} \mathrm{C}$ |
| ead Temperature Range (So | $+300^{\circ} \mathrm{C}$ |

## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2} 8$-Pin Plastic Package: $\theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} / \mathrm{W}$ att, $\theta_{\mathrm{JC}}=50^{\circ} \mathrm{C} /$ Watt
8 -Pin Plastic SOIC Package: $\theta_{\mathrm{JA}}=160^{\circ} \mathrm{C} / \mathrm{Watt}, \theta_{\mathrm{JC}}=42^{\circ} \mathrm{C} / \mathrm{Watt}$

## ESD SUSCEPTIBILITY

An ESD classification per method 3015.6 of MIL STD 883C has been performed on the AD626, which is a Class 1 device.

## ORDERING GUIDE

| Model | Temperature Range | Package Options ${ }^{\star}$ |
| :--- | :--- | :--- |
| AD626AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| AD626AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-8$ |
| AD626BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |

* $\mathrm{N}=$ Plastic DIP; $\mathrm{R}=$ Small Outline IC. For outline information see Package Information section


## METALIZATION PHOTOGRAPH

Dimensions shown in inches and (mm),


# Low Noise, Precision Instrumentation Amplifier 



## FEATURES

- Low Offset Voltage . .............................. . $50 \mu \mathrm{~V}$ Max
- Very Low Offset Voltage Drift ............. $0.3 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ Max
- Low Noise . . . . . . . . . . . . . . . . . . $0.12 \mu \mathrm{~V}_{\mathrm{p}-\mathrm{p}} \mathbf{( 0 . 1 \mathrm { Hz } \text { to } \mathbf { 1 0 H z } )}$
- Excellent Output Drive ................. $\pm 10 \mathrm{~V}$ at $\pm 50 \mathrm{~mA}$
- Capacitive Load Stability . . . . . . . . . . . . . . . . . . . . . to $1 \mu \mathrm{~F}$
- Gain Range ..................................... 0.1 to 10,000
- Excellent Linearity . . . . . . . . . . . . . . . . . . 16-Bit at G = 1000
- High CMR . . . . . . . . . . . . . . . . . . . . . . . . 125dB Min (G = 1000)
- Low Bias Current

4nA Max

- May be Configured as a Precision Op-Amp
- Output-Stage Thermal Shutdown
- Available in Die Form


## ORDERING INFORMATION $\dagger$

|  | PACKAGE |  | OPERATING <br> CEMPERATURE <br> CERDIP <br> 18-PIN |
| :---: | :---: | :---: | :---: |
| AMP01AX* | LCC | PLASTIC <br> RANGE |  |
| AMP01BX* | AMP01BTC/883 | - | MIL |
| AMP01EX | - | - | MIL |
| AMP01FX | - | - | IND |
| - | - | AMP01GS $\dagger \dagger$ | COM |

* For devices processed in total compliance to MIL-STD-883, add/883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.
t† For availability and burn-in information on SO and PLCC packages, contact your local sales office.


## PIN CONNECTIONS


*Make no electrical connection to these pins.

SIMPLIFIED SCHEMATIC


Manufactured under the following U.S. patents: 4,471,321 and 4,503,381.
This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

## AMP01

## GENERAL DESCRIPTION

The AMP-01 is a monolithic instrumentation amplifier designed for high-precision data acquisition and instrumentation applications. The design combines the conventional features of an instrumentation amplifier with a high-current output stage. The output remains stable with high capacitance loads ( $1 \mu \mathrm{~F})$, a unique ability for an instrumentation amplifier. Consequently, the AMP-01 can amplify low-level signals for transmission through long cables without requiring an output buffer. The output stage may be configured as a voltage or current generator.
Input offset voltage is very low ( $20 \mu \mathrm{~V}$ ) which generally eliminates the external null potentiometer. Temperature changes have minimal effect on offset; TCV 10 is typically $0.15 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$. Excellent low-frequency noise performance is achieved with a minimal compromise on input protection. Bias current is very low, less than 10nA over the military temperature range. High common-mode rejection of 130 dB , 16 -bit linearity at a gain of 1000 , and 50 mA peak output current are achievable simultaneously. This combination takes the instrumentation amplifier one step further towards the ideal amplifier.

AC performance complements the superb DC specifications. The AMP-01 slews at $4.5 \mathrm{~V} / \mu \mathrm{s}$ into capacitive loads of up to 15 nF , settles in $50 \mu \mathrm{~s}$ to $0.01 \%$ at a gain of 1000 , and boasts a healthy 26 MHz gain-bandwidth product. These features make the AMP-01 ideal for high-speed data-acquisition systems.
Gain is set by the ratio of two external resistors over a range of 0.1 to 10,000. A very low gain-temperature-coefficient of $10 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ is achievable over the whole gain range. Output voltage swing is guaranteed with three load resistances; $50 \Omega$, $500 \Omega$, and $2 \mathrm{k} \Omega$. Loaded with $500 \Omega$, the output delivers $\pm 13.0 \mathrm{~V}$ minimum. A thermal shutdown circuit prevents destruction of the output transistors during overload conditions.
The AMP-01 can also be configured as a high-performance operational amplifier. In many applications, the AMP-01 can be used in place of op-amp/power-buffer combinations.

## THEORY OF OPERATION

An instrumentation amplifier, unlike an op amp, requires precise internal feedback. The two techniques presently in use are resistive and current feedback.
The AMP-01 employs the current feedback approach which has significant advantages over resistive feedback. Advantages of current-feedback are:
a. The technique yields a very high common-mode rejection ratio. The AMP-01 CMR is in excess of 130 dB at a gain of 1000.
b. The gain of the current feedback design is set by the ratio of two external resistors. Using external resistors allows any practical gain to be set with high precision and very low gain temperature coefficient.
c. The current-feedback design is immune to CMR degradation when series resistance is added to the reference input. A small (trimmable) offset change results from added resistance, e.g. a printed circuit track.
The AMP-01 utilizes low-drift thin-film resistors to minimize output offset temperature drift. A feedback voltage-to-current converter is employed having high linearity and low noise, particularly at low frequencies. Parameter shifts during packaging are eliminated by a post-assembly trimming technique which electronically adjusts the output offset voltage.
The AMP-01 input transistors Q1 and Q2 feed active loads, yielding stage gain in excess of 4000 (see simplified schematic) The output amplifier, A1, is a two-stage design having a gain of about 50,000 driving a $100 \Omega$ load. Overall gain of $2 \times 10^{8}$ yields excellent linearity, even at high closed-loop gains.
Low bias current is achieved by using lon-implanted superbeta transistors combined with a new bias-current cancellation system, patents applied for. Input bias current remains below 10nA over the military temperature range, $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.

Superbeta transistors use a new transistor geometry resulting in an input noise of only $5 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ at $\mathrm{G}=1000$. Noise includes contributions from the gain-setting resistor and internal overload-protection resistor. The input stage achieves an offset voltage drift of less than $0.3 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ (E Grade).

The AMP-01 uses a unique two-pole compensation scheme where the load capacitance is incorporated into the dominate pole. Stable operation results even with high capacitance loads. The high output current capability ( 90 mA peak) allows the $4.5 \mathrm{~V} / \mu \mathrm{s}$ slew-rate to be maintained with load capacitance as high as 15 nF .

## ABSOLUTE MAXIMUM RATINGS (Note 1)

Supply Voltage $\pm 18 \mathrm{~V}$ Common-Mode Input Voltage ......................... Supply Voltage Differential Input Voltage, $\mathrm{R}_{\mathrm{G}} \mathbf{2} \mathbf{2 k} \Omega \ldots . . . . . . . . . . . . . . . . . . . . . . . . . . . . . ~ \pm 20 V ~$ $R_{F}<2 k \Omega \ldots \ldots \ldots \ldots \ldots . . . . . . . . . . . . . . . . . . . . . . . .10 \mathrm{~V}$ Output Short-Circuit Duration .................................. Indefinite Storage Temperature Range ........................ $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ Operating Temperature Range
AMP-01A, B ............................................... $-55^{\circ} \mathrm{C}$ to $+^{125^{\circ}} \mathrm{C}$

AMP-01E, F ................................................. $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
AMP-01G ......................................................... $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ Lead Temperature (Soldering, 60 sec ) ........................... $300^{\circ} \mathrm{C}$ Junction Temperature ( $T_{i}$ ) ............................ $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

| PACKAGE TYPE | $\Theta^{\prime 4}$ (Note 2) | $\theta_{\text {jc }}$ | UNITS |
| :---: | :---: | :---: | :---: |
| 18-Pin Hermetic DIP (Z) | 79 | 11 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 28-Contact LCC (TC) | 78 | 30 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 20-Pin SOL (S) | 88 | 25 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTES:

1. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
2. $\Theta_{j A}$ is specified for worst case mounting conditions, i.e., $\Theta_{j A}$ is specified for device in socket for CerDIP and LCC packages; $\Theta_{\mathrm{IA}}$ is specified for device soldered to printed circuit board for SOL package.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{R}_{\mathrm{S}}=10 \mathrm{k} \Omega, \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | AMP-01A |  |  | AMP-01B |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX |  |
| OFFSET VOLTAGE |  |  |  |  |  |  |  |  |  |
| Input Offset Voltage | V10s | $\begin{aligned} & T_{A}=25^{\circ} \mathrm{C} \\ & -55^{\circ} \mathrm{C} \leq T_{A} \leq+125^{\circ} \mathrm{C} \end{aligned}$ | - | 20 40 | $\begin{aligned} & 50 \\ & 80 \end{aligned}$ | - | 40 60 | $\begin{aligned} & 100 \\ & 150 \\ & \hline \end{aligned}$ | $\mu \mathrm{V}$ |
| Input Offset Voltage Drift | TCV ${ }_{\text {IOS }}$ | $-55^{\circ} \mathrm{C} \leq \mathrm{T}_{A} \leq+125^{\circ} \mathrm{C}$ | - | 0.15 | 0.3 | - | 0.3 | 1.0 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Output Offset Voltage | Voos | $\begin{aligned} & T_{A}=25^{\circ} \mathrm{C} \\ & -55^{\circ} \mathrm{C} \leq T_{A} \leq+125^{\circ} \mathrm{C} \end{aligned}$ | - | 1 3 | 3 6 | - | 2 6 | $\begin{array}{r}6 \\ 10 \\ \hline\end{array}$ | mV |
| Output Offset Voltage Drift | TCV ${ }_{\text {OOS }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{G}}=\infty \\ & -55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C} \end{aligned}$ | - | 20 | 50 | - | 50 | 120 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Offset Referred to Input vs. Positive Supply $V+=+5 \mathrm{~V}$ to +15 V | PSR | $\mathrm{G}=1000$ | 120 | 130 | - | 110 | 120 | - |  |
|  |  | $\mathrm{G}=100$ | 110 | 130 | - | 100 | 120 | - | dB |
|  |  | $\mathrm{G}=10$ | 95 | 110 | - | 90 | 100 | - | dB |
|  |  | $\mathrm{G}=1$ | 75 | 90 | - | 70 | 80 | - |  |
|  |  | $-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ |  |  |  |  |  |  |  |
|  |  | $\mathrm{G}=1000$ | 120 | 130 | - | 110 | 120 | - |  |
|  |  | $\mathrm{G}=100$ | 110 | 130 | - | 100 | 120 | - | dB |
|  |  | $\mathrm{G}=10$ | 95 | 110 | - | 90 | 100 | - | dB |
|  |  | $\mathrm{G}=1$ | 75 | 90 | - | 70 | 80 | - |  |
| Offset Referred to Input vs. Negative Supply $\mathrm{V}-=-5 \mathrm{~V}$ to -15 V | PSR | $G=1000$ | 105 | 125 | - | 105 | 115 | - | dB |
|  |  | $\mathrm{G}=100$ | 90 | 105 | - | 90 | 95 | - |  |
|  |  | $\mathrm{G}=10$ | 70 | 85 | - | 70 | 75 | - |  |
|  |  | $\mathrm{G}=1$ | 50 | 65 | - | 50 | 60 | - |  |
|  |  | $\begin{aligned} & -55^{\circ} \mathrm{C} \leq T_{A} \leq+125^{\circ} \mathrm{C} \\ & G=1000 \end{aligned}$ | 105 | 125 | - | 105 | 115 | - |  |
|  |  | $G=100$ $G=100$ | 90 | 105 | - | 90 | 95 | - |  |
|  |  | $\mathrm{G}=10$ | 70 | 85 | - | 70 | 75 | - | dB |
|  |  | $\mathrm{G}=1$ | 50 | 65 | - | 50 | 60 | - |  |
| Input Offset Voltage Trim Range |  | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}= \pm 4.5 \mathrm{~V} \text { to } \pm 18 \mathrm{~V} \\ & \text { (Note 1) } \end{aligned}$ | - | $\pm 6$ | - | - | $\pm 6$ | - | mV |
| Output Offset Voltage Trim Range |  | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}= \pm 4.5 \mathrm{~V} \text { to } \pm 18 \mathrm{~V} \\ & \text { (Note 1) } \end{aligned}$ | - | $\pm 100$ | - | - | $\pm 100$ | - | mV |
| INPUT CURRENT |  |  |  |  |  |  |  |  |  |
| Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ | $\begin{aligned} & T_{A}=25^{\circ} \mathrm{C} \\ & -55^{\circ} \mathrm{C} \leq \mathrm{T}_{A} \leq+125^{\circ} \mathrm{C} \end{aligned}$ | - | 1 4 | $\begin{array}{r}4 \\ 10 \\ \hline\end{array}$ | - | 2 <br> 6 | $\begin{array}{r}6 \\ 15 \\ \hline\end{array}$ | $n \mathrm{~A}$ |
| Input Bias Current Drift | $\mathrm{TCl}_{\mathrm{B}}$ | $-55^{\circ} \mathrm{C} \leq \mathrm{T}_{A} \leq+125^{\circ} \mathrm{C}$ | - | 40 | - | - | 50 | - | $\mathrm{pA} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Current | los | $\begin{aligned} & T_{A}=25^{\circ} \mathrm{C} \\ & -55^{\circ} \mathrm{C} \leq T_{A} \leq+125^{\circ} \mathrm{C} \end{aligned}$ | - | $\begin{aligned} & 0.2 \\ & 0.5 \end{aligned}$ | $\begin{aligned} & 1.0 \\ & 3.0 \end{aligned}$ | - | 0.5 1.0 | 2.0 <br> 6.0 | $n A$ |
| Input Offset Current Drift | $\mathrm{TCl}_{\mathrm{os}}$ | $-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ | - | 3 | - | - | 5 | - | $\mathrm{pA} /{ }^{\circ} \mathrm{C}$ |
| INPUT |  |  |  |  |  |  |  |  |  |
| Input Resistance | $\mathrm{R}_{\text {IN }}$ | Differential, G = 1000 | - | 1 | - | - | 1 | - | $\mathrm{G} \Omega$ |
|  |  | Differential, $\mathrm{G} \leq 100$ | - | 10 | - | - | 10 | - |  |
|  |  | Common-Mode, G $=1000$ | - | 20 | - | - | 20 | - |  |
| Input Voltage Range | IVR | $\begin{aligned} & T_{A}=25^{\circ} \mathrm{C} \text { (Note 2) } \\ & -55^{\circ} \mathrm{C} \leq T_{A} \leq+125^{\circ} \mathrm{C} \end{aligned}$ | $\begin{array}{r}  \pm 10.5 \\ \pm 10.0 \\ \hline \end{array}$ | - | - | $\begin{aligned} & \pm 10.5 \\ & \pm 10.0 \\ & \hline \end{aligned}$ | - | - | V |
| Common-Mode Rejection | CMR | $\begin{aligned} & \mathrm{V}_{\mathrm{CM}}= \pm 10 \mathrm{~V}, 1 \mathrm{k} \Omega \\ & \text { source imbalance } \end{aligned}$ |  |  |  |  |  |  | dB |
|  |  | $G=1000$ | 125 | 130 | - | 115 | 125 | - |  |
|  |  | $\mathrm{G}=100$ | 120 | 130 | - | 110 | 125 | - |  |
|  |  | $\mathrm{G}=10$ | 100 | 120 | - | 95 | 110 | - |  |
|  |  | $\mathrm{G}=1$ | 85 | 100 | - | 75 | 90 | - |  |
|  |  | $-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ |  |  |  |  |  |  | dB |
|  |  | $\mathrm{G}=1000$ | 120 | 125 | - | 110 | 120 | - |  |
|  |  | $\mathrm{G}=100$ | 115 | 125 | - | 105 | 120 | - |  |
|  |  | $\mathrm{G}=10$ | 95 | 115 | - | 90 | 105 | - |  |
|  |  | $\mathrm{G}=1$ | 80 | 95 | - | 75 | 90 | - |  |

## NOTES:

[^207]
## AMP01

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{S}= \pm 15 \mathrm{~V}, \mathrm{R}_{\mathrm{S}}=10 \mathrm{k} \Omega, \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C},-25^{\circ} \mathrm{C} \leq \mathrm{T}_{A} \leq+85^{\circ} \mathrm{C}$ for $\mathrm{E}, \mathrm{F}$ grades, $0^{\circ} \mathrm{C} \leq T_{A} \leq+70^{\circ} \mathrm{C}$ for G grade, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | AMP-01E |  |  | AMP-01F/G |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | UNITS |
| OFFSET VOLTAGE |  |  |  |  |  |  |  |  |  |
| Input Offset Voltage | $V_{10 s}$ | $\begin{aligned} & T_{A}=+25^{\circ} \mathrm{C} \\ & T_{M I N} \leq T_{A} \leq T_{M A X} \end{aligned}$ | - | 20 40 | $\begin{aligned} & 50 \\ & 80 \end{aligned}$ | - | 40 | $\begin{aligned} & 100 \\ & 150 \end{aligned}$ | $\mu \mathrm{V}$ |
| Input Offset Voltage Drift | TCV ${ }_{\text {IOS }}$ | $\mathrm{T}_{\text {MIN }} \leq \mathrm{T}_{A} \leq \mathrm{T}_{\text {MAX }}$ (Note 2) | - | 0.15 | 0.3 | - | 0.3 | 1.0 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Output Offset Voltage | $V_{\text {oos }}$ | $\begin{aligned} & T_{A}=+25^{\circ} \mathrm{C} \\ & T_{\text {MIN }} \leq T_{A} \leq T_{M A X} \end{aligned}$ | - | 1 3 | 3 6 | - | 2 | 6 10 | mV |
| Output Offset Voltage Drift | $\mathrm{TCV}_{\text {Oos }}$ | $\begin{aligned} & R G=\infty \text { (Note } 2) \\ & T_{\text {MIN }} \leq T_{A} \leq T_{\text {MAX }} \end{aligned}$ | - | 20 | 100 | - | 50 | 120 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Offset Referred to Input vs. Positive Supply $\mathrm{V}+=+5 \mathrm{~V}$ to +15 V | PSR | $\mathrm{G}=1000$ | 120 | 130 | - | 110 | 120 | - |  |
|  |  | $\mathrm{G}=100$ | 110 | 130 | - | 100 | 120 | - | dB |
|  |  | $\mathrm{G}=10$ | 95 | 110 | - | 90 | 100 | - | dB |
|  |  | $\mathrm{G}=1$ | 75 | 90 | - | 70 | 80 | - |  |
|  |  | $\begin{gathered} T_{\text {MIN }} \leq T_{A} \leq T_{M A X} \\ G=1000 \end{gathered}$ | 120 | 130 | - | 110 | 120 | - |  |
|  |  | $\mathrm{G}=100$ | 110 | 130 | - | 100 | 120 | - | dB |
|  |  | $\mathrm{G}=10$ | 95 | 110 | - | 90 | 100 | - | dB |
|  |  | $\mathrm{G}=1$ | 75 | 90 | - | 70 | 80 | - |  |
| Offset Referred to Input vs. Negative Supply $\mathrm{V}-=-5 \mathrm{~V}$ to -15 V | PSR | $\mathrm{G}=1000$ | 110 | 125 | - | 105 | 115 | - |  |
|  |  | $\mathrm{G}=100$ | 95 | 105 | - | 90 | 95 | - | dB |
|  |  | $\mathrm{G}=10$ | 75 | 85 | - | 70 | 75 | - | dB |
|  |  | $\mathrm{G}=1$ | 55 | 65 | - | 50 | 60 | - |  |
|  |  | $\begin{gathered} T_{\text {MIN }} \leq T_{A} \leq T_{M A X} \\ G=1000 \end{gathered}$ | 110 | 125 | - | 105 | 115 | - |  |
|  |  | $\mathrm{G}=100$ | 95 | 105 | - | 90 | 95 | - | dB |
|  |  | $\mathrm{G}=10$ | 75 | 85 | - | 70 | 75 | - | dB |
|  |  | $\mathrm{G}=1$ | 55 | 65 | - | 50 | 60 | - |  |
| Input Offset Voltage Trim Range |  | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}= \pm 4.5 \mathrm{~V} \text { to } \pm 18 \mathrm{~V} \\ & \text { (Note 1) } \end{aligned}$ | - | $\pm 6$ | - | - | $\pm 6$ | - | mV |
| Output Offset Voltage Trim Range |  | $\begin{aligned} & V_{\mathrm{S}}= \pm 4.5 \mathrm{~V} \text { to } \pm 18 \mathrm{~V} \\ & \text { (Note 1) } \end{aligned}$ | - | $\pm 100$ | - | - | $\pm 100$ | - | mV |
| INPUT CURRENT |  |  |  |  |  |  |  |  |  |
| Input Bias Current | $I_{B}$ | $\begin{aligned} & T_{A}=+25^{\circ} \mathrm{C} \\ & T_{\text {MIN }} \leq T_{A} \leq T_{\text {MAX }} \end{aligned}$ | - | 1 4 | 4 10 | - | 2 | 6 15 | mV |
| Input Bias Current Drift | $\mathrm{TCl}_{\mathrm{B}}$ | $\mathrm{T}_{\text {MIN }} \leq T_{A} \leq \mathrm{T}_{\text {MAX }}$ | - | 40 | - | - | 50 | - | $\mathrm{pA}^{\circ} \mathrm{C}$ |
| Input Offset Current | $I_{B}$ | $\begin{aligned} & T_{A}=+25^{\circ} \mathrm{C} \\ & T_{\text {MIN }} \leq T_{A} \leq T_{\text {MAX }} \end{aligned}$ | - | $\begin{aligned} & 0.2 \\ & 0.5 \end{aligned}$ | $\begin{aligned} & 1.0 \\ & 3.0 \end{aligned}$ | - | 0.5 1.0 | $\begin{aligned} & 2.0 \\ & 6.0 \end{aligned}$ | mV |
| Input Offset Current Drift | $\mathrm{TCl}_{\text {OS }}$ | $T_{\text {MIN }} \leq T_{A} \leq T_{\text {MAX }}$ | - | 3 | - | - | 5 | - | $\mathrm{pA}{ }^{\circ} \mathrm{C}$ |
| INPUT |  |  |  |  |  |  |  |  |  |
| Input Resistance | $\mathrm{R}_{\mathbf{I N}}$ | Differential, G=1000 | - | 1 | - | - | 1 | - |  |
|  |  | Differential, $\mathrm{G} \leq 100$ | - | 10 | - | - | 10 | - | G $\Omega$ |
|  |  | Common-Mode, G = 1000 | - | 20 | - | - | 20 | - |  |
| Input Voltage Range | IVR | $T_{A}=+25^{\circ} \mathrm{C} \text { (Note 3) }$ | $\pm 10.5$ | - | - | $\pm 10.5$ | - | - | V |
|  |  | $T_{M I N} \leq T_{A} \leq T_{M A X}$ | $\pm 10.0$ | - | - | $\pm 10.0$ | - | - |  |
| Common-Mode Rejection | CMR | $\begin{aligned} & \mathrm{V}_{\mathrm{CM}}= \pm 10 \mathrm{~V}, 1 \mathrm{k} \Omega \\ & \text { source imbalance } \end{aligned}$ |  |  |  |  |  | , | dB |
|  |  | $\mathrm{G}=1000$ | 125 | 130 | - | 115 | 125 | - |  |
|  |  | $\mathrm{G}=100$ | 120 | 130 | - | 110 | 125 | - |  |
|  |  | $\mathrm{G}=10$ | 100 | 120 | - | 95 | 110 | - |  |
|  |  | $\mathrm{G}=1$ | 85 | 100 | - | 75 | 90 | - |  |
|  |  | $\begin{aligned} & T_{M I N} \leq T_{A} \leq T_{M A X} \\ & G=1000 \end{aligned}$ | 120 | 125 | - | 110 | 120 | - | dB |
|  |  | $G=100$ | 115 | 125 | - | 105 | 120 | - |  |
|  |  | $G=10$ | 95 | 115 | - | 90 | 105 | - |  |
|  |  | $\mathrm{G}=1$ | 80 | 95 | - | 75 | 90 | - |  |

## NOTES:

[^208]ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{R}_{\mathrm{S}}=10 \mathrm{k} \Omega, \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | AMP-01A/E |  |  | AMP-01B/F/G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX |  |
| GAIN |  |  |  |  |  |  |  |  |  |
| Gain Equation Accuracy |  | $\mathrm{G}=\frac{20 \times \mathrm{R}_{\mathrm{S}}}{\mathrm{R}_{\mathrm{G}}}$ <br> Accuracy Measured from $G=1$ to 1000 | - | 0.3 | 0.6 | - | 0.5 | 0.8 | \% |
| Gain Range | G |  | 0.1 | - | 10k | 0.1 | - | 10k | V/V |
| Nonlinearity |  | $\mathrm{G}=1000$ | - | 0.0007 | 0.005 | - | 0.0007 | 0.005 |  |
|  |  | $G=100$ <br> (Note 1) | - | - | 0.005 | - | - | $0.005$ | - \% |
|  |  | $\mathrm{G}=10$ | - | - | 0.005 | - | - | $0.007$ | \% |
|  |  | $\mathrm{G}=1$ | - | - | 0.010 | - | - | 0.015 |  |
| Temperature Coefficient | $\mathrm{G}_{\text {TC }}$ | $\begin{aligned} & 1 \leq \mathrm{G} \leq 1000 \\ & (\text { Notes } 1,2) \end{aligned}$ | - | 5 | 10 | - | 5 | 15 | ppm $/{ }^{\circ} \mathrm{C}$ |
| OUTPUT RATING |  |  |  |  |  |  |  |  |  |
| Output Voltage Swing | Vout | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | $\pm 13.0$ | $\pm 13.8$ | - | $\pm 13.0$ | $\pm 13.8$ | - |  |
|  |  | $\mathrm{R}_{\mathrm{L}}=500 \Omega$ | $\pm 13.0$ | $\pm 13.5$ | - | $\pm 13.0$ | $\pm 13.5$ | - | v |
|  |  | $R_{L}=50 \Omega$ | $\pm 2.5$ | $\pm 4.0$ | - | $\pm 2.5$ | $\pm 4.0$ | - |  |
|  |  | $R_{L}=2 k \Omega \quad$ Over Temp. | $\pm 12.0$ | $\pm 13.8$ | - | $\pm 12.0$ | $\pm 13.8$ | - | V |
|  |  | $R_{L}=500 \Omega \quad$ (Note 3) | $\pm 12.0$ | $\pm 13.5$ | - | $\pm 12.0$ | $\pm 13.5$ | - |  |
| Positive Current Limit |  | Output-to-Ground Short | 60 | 100 | 120 | 60 | 100 | 120 | mA |
| Negative Current Limit |  | Output-to-Ground Short | 60 | 90 | 120 | 60 | 90 | 120 | mA |
| Capacitive Load Stability |  | $1 \leq G \leq 1000$ <br> No Oscillations, (Note 1) | 0.1 | 1 | - | 0.1 | 1 | - | $\mu \mathrm{F}$ |
| Thermal Shutdown Temperature |  | Junction Temperature | - | 165 | - | - | 165 | - | ${ }^{\circ} \mathrm{C}$ |
| NOISE |  |  |  |  |  |  |  |  |  |
| Voltage Density, RTI | $e_{n}$ | $\mathrm{f}_{\mathrm{O}}=1 \mathrm{kHz}$ |  |  |  |  |  |  | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
|  |  | $\mathrm{G}=1000$ | - | 5 | - | - | 5 | - |  |
|  |  | $\mathrm{G}=100$ | - | 10 | - | - | 10 | - |  |
|  |  | $\mathrm{G}=10$ | - | 59 | - | - | 59 | - |  |
|  |  | $\mathrm{G}=1$ | - | 540 | - | - | 540 | - |  |
| Noise Current Density, RTI | $i_{n}$ | $f_{0}=1 \mathrm{kHz}, \mathrm{G}=1000$ | - | 0.15 | - | - | 0.15 | - | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
| Input Noise Voltage | $e_{\text {np-p }}$ | 0.1 Hz to 10 Hz |  |  |  |  |  |  | $\mu \mathrm{V}_{\mathrm{p} \text {-p }}$ |
|  |  | $\mathrm{G}=1000$ | - | 0.12 | - | - | 0.12 | - |  |
|  |  | $\mathrm{G}=100$ | - | 0.16 | - | - | 0.16 | - |  |
|  |  | $\mathrm{G}=10$ | - | 1.4 | - | - | 1.4 | - |  |
|  |  | $\mathrm{G}=1$ | - | 13 | - | - | 13 | - |  |
| Input Noise Current | $i_{\text {np-p }}$ | 0.1 Hz to $10 \mathrm{~Hz}, \mathrm{G}=1000$ | - | 2 | - | - | 2 | - | $p A_{p-p}$ |
| DYNAMIC RESPONSE |  |  |  |  |  |  |  |  |  |
| Small-Signal Bandwidth ( -3 dB ) | BW | $G=1$ | - | 570 | - | - | 570 | - | kHz |
|  |  | $\mathrm{G}=10$ | - | 100 | - | - | 100 | - |  |
|  |  | $\mathrm{G}=100$ | - | 82 | - | - | 82 | - |  |
|  |  | $\mathrm{G}=1000$ | - | 26 | - | - | 26 | - |  |
| Slew Rate | SR | $\mathrm{G}=10$ | 3.5 | 4.5 | - | 3.0 | 4.5 | - | $\mathrm{V} / \mu \mathrm{s}$ |
| Settling Time | $t_{s}$ | To $0.01 \%$, 20V step |  |  |  |  |  |  | $\mu \mathrm{S}$ |
|  |  | $\mathrm{G}=1$ | - | 12 | - | - | 12 | - |  |
|  |  | $\mathrm{G}=10$ | - | 13 | - | - | 13 | - |  |
|  |  | $\mathrm{G}=100$ | - | 15 | - | - | 15 | - |  |
|  |  | $\mathrm{G}=1000$ | - | 50 | - | - | 50 | - |  |

## NOTES:

1. Guaranteed by design.
2. Gain tempco does not include the effects of gain and scale resistor tempco match.
3. $-55^{\circ} \mathrm{C} \leq T_{A} \leq+125^{\circ} \mathrm{C}$ for $A / B$ grades, $-25^{\circ} \mathrm{C} \leq T_{A} \leq+85^{\circ} \mathrm{C}$ for $E / F$ grades, $0^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq 70^{\circ} \mathrm{C}$ FOR G grades.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{R}_{\mathrm{S}}=10 \mathrm{k} \Omega, \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | AMP-01A/E |  |  | AMP-01B/F/G |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP ${ }^{-}$ | MAX | MIN | TYP | MAX |  |
| SENSE INPUT |  |  |  |  |  |  |  |  |  |
| Input Resistance | $\mathrm{R}_{\text {IN }}$ |  | 35 | 50 | 65 | 35 | 50 | 65 | $\mathrm{k} \Omega$ |
| Input Current | $\mathrm{I}_{\text {IN }}$ | Referenced to V- | - | 280 | - | - | 280 | - | $\mu \mathrm{A}$ |
| Voltage Range |  | (Note 1) | -10.5 | - | +15 | -10.5 | - | +15 | V |
| REFERENCE INPUT |  |  |  |  |  |  |  |  |  |
| Input Resistance | $\mathrm{R}_{\text {IN }}$ | , | 35 | 50 | 65 | 35 | 50 | 65 | $\mathrm{k} \Omega$ |
| Input Current | $\mathrm{I}_{\mathrm{IN}}$ | Referenced to V - | - | 280 | - | - | 280 | - | $\mu \mathrm{A}$ |
| Voltage Range |  | (Note 1) | -10.5 | - | +15 | -10.5 | - | +15 | V |
| Gain to Output |  |  | - | 1 | - | - | 1 | - | V/V |
| POWER SUPPLY $-25^{\circ} \mathrm{C} \leq T_{A} \leq+85^{\circ} \mathrm{C}$ for E/F Grades, $-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$ for $\mathrm{A} / \mathrm{B}$ Grades |  |  |  |  |  |  |  |  |  |
| Supply Voltage Range | $\mathrm{V}_{\mathrm{S}}$ | $\begin{aligned} & +V \text { linked to }+V_{O P} \\ & -V \text { linked to }-V_{O P} \end{aligned}$ | $\pm 4.5$ | - | $\pm 18$ | $\pm 4.5$ | - | $\pm 18$ | V |
| Quiescent Current | ${ }_{1}$ | $\begin{aligned} & +V \text { linked to }+V_{O P} \\ & -V \text { linked to }-V_{O P} \end{aligned}$ | - | 3.0 3.4 | 4.8 4.8 | - | 3.0 3.4 | 4.8 4.8 | mA |

NOTE:

1. Guaranteed by design.

# High Accuracy 8-Pin Instrumentation Amplifier 

## FEATURES

- Low Offset Voltage ............................................ 100 1 V Max
- Low Drift ........................................................... $2 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ Max
- Wide Gain Range ............................................... 1 to 10,000
- High Common-Mode Rejection ....................... 115dB Min
- High Bandwidth ( $G=1000$ ) ............................. 200kHz Typ
- Gain Equation Accuracy .................................... 0.5\% Max
- Single Resistor Gain Set
- Input Overvoltage Protection
- Low Cost
- Avallable in Dle Form


## APPLICATIONS

- Differential Amplifier
- Strain Gauge Amplifier
- Thermocouple Amplifier
- RTD Amplifier
- Programmable Gain Instrumentation Amplifier
- Medical Instrumentation
- Data Acquisition Systems


## ORDERING INFORMATION ${ }^{\dagger}$

| $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |  | $\begin{aligned} & \text { PLASTIC } \\ & \text { 8-PIN } \end{aligned}$ | OPERATING TEMPERATURE RANGE |
| :---: | :---: | :---: | :---: |
| $\underset{(\mu \mathrm{V})}{V_{\text {10s }} \text { MAX }}$ | $\underset{\substack{\left.\mathrm{V}_{\mathrm{oos}} \\ \mathrm{mV}\right)}}{\text { MAX }}$ |  |  |
| 100 | 4 | AMP02EP | XIND |
| 200 | 8 | AMP02FP | XIND |

$\mp$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.

## GENERAL DESCRIPTION

The AMP-02 is the first precision instrumentation amplifier available in an 8 -pin package. Gain of the AMP-02 is set by a single external resistor, and can range from 1 to 10,000. No gain set resistor is required for unity gain. The AMP-02 includes an input protection network that allows the inputs to be taken 60 V beyond either supply rail without damaging the device.
Laser trimming reduces the input offset voltage to under $100 \mu \mathrm{~V}$. Output offset voltage is below 4 mV and gain accuracy is better than $0.5 \%$ for gain of 1000. PMI's proprietary thin-film resistor process keeps the gain temperature coefficient under 50 ppm $/{ }^{\circ} \mathrm{C}$.
Due to the AMP-02's design, its bandwidth remains very high over a wide range of gain. Slew rate is over $4 \mathrm{~V} / \mu \mathrm{s}$ making the AMP-02 ideal for fast data acquisition systems.

A reference pin is provided to allow the output to be referenced to an external DC level. This pin may be used for offset correction or level shifting as required. In the 8-pin package, sense is internally connected to the output.

For an instrumentation amplifier with the highest precision, consult the AMP-01 data sheet. For the highest input impedance and speed, consult the AMP-05 data sheet.

## PIN CONNECTIONS



## BASIC CIRCUIT CONNECTIONS



[^209]
## ABSOLUTE MAXIMUM RATINGS



| PACKAGE TYPE | $\Theta_{\text {Ja }}$ (Note 2) | $\Theta_{\text {JC }}$ | UNITS |
| :--- | :---: | :---: | :---: |
| 8 8-Pin Plastic DIP (P) | 96 | 37 | ${ }^{\circ} \mathrm{CM}$ |
| 16-Pin SOL (S) | 92 | 27 | ${ }^{\circ} \mathrm{CW}$ |

NOTE:

1. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
2. $\Theta_{j A}$ is specified for worst case mounting conditions, i.e., $\Theta_{j A}$ is specified for device in socket for P-DIP package; $\boldsymbol{\Theta}_{\mathrm{jA}}$ is specified for device soldered to printed circuit board for SOL package.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.


ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted. Continued


## NOTES:

1. Guaranteed by design.
2. Gain tempco does not include the effects of external component drift.
3. Input voltage range guaranteed by common-mode rejection test.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted. Continued

| PARAMETER | SYMBOL | CONDITIONS | MIN AMP-02E |  | MAX | AMP-02F |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SENSE INPUT |  |  |  |  |  |  |  |  |  |
| Input Resistance | $\mathrm{R}_{\text {IN }}$ |  | - | 25 | - | - | 25 | - | k $\Omega$ |
| Voltage Range |  |  | - | $\pm 11$ | - | - | $\pm 11$ | - | v |
| REFERENCE INPUT |  |  |  |  |  |  |  |  |  |
| Input Resistance | $\mathrm{R}_{\text {IN }}$ |  | - | 50 | - | - | 50 | - | k $\Omega$ |
| Voltage Range |  |  | - | $\pm 11$ | - | - | $\pm 11$ | - | v |
| Gain to Output |  |  | - | 1 | - | - | 1 | - | V/V |
| POWER SUPPLY |  |  |  |  |  |  |  |  |  |
| Supply Voltage Range | $\mathrm{V}_{\text {s }}$ |  | $\pm 4.5$ | - | $\pm 18$ | $\pm 4.5$ | - | $\pm 18$ | V |
| Supply Current | $I_{S Y}$ | $\begin{aligned} & T_{A}=+25^{\circ} \mathrm{C} \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{A} \leq+85^{\circ} \mathrm{C} \end{aligned}$ | - | $5$ | 6 | - | $5$ | 6 6 | mA |

SIMPLIFIED SCHEMATIC


## FEATURES

Single Supply Operation<br>Low Supply Current: $700 \mu \mathrm{~A}$ max<br>Wide Gain Range: 1 to 1000<br>Low Offset Voltage: $150 \mu \mathrm{~V}$ max<br>Zero-In/Zero-Out<br>Single-Resistor Gain Set<br>8-pin Mini-DIP and SO packages

APPLICATIONS
Strain Gages
Thermocouples
RTDs
Battery Powered Equipment
Medical Instrumentation
Data Acquisition Systems
PC Based Instruments
Portable Instrumentation

## GENERAL DESCRIPTION

The AMP-04 is a single-supply instrumentation amplifier designed to work over a +5 volt to $\pm 15$ volt supply range. It offers an excellent combination of accuracy, low power consumption, wide input voltage range, and excellent gain performance.
Gain is set by a single external resistor and can be from 1 to 1000. Input common-mode voltage range allows the AMP-04 to handle signals with full accuracy from ground to within 1 volt of the positive supply. And the output can swing to within 1 volt of the positive supply. Gain bandwidth is over 700 kHz . In addition to being easy to use, the AMP-04 draws only $700 \mu \mathrm{~A}$ of supply current.
For high resolution data acquisition systems, laser trimming of low drift thin-film resistors limits the input offset voltage to under $150 \mu \mathrm{~V}$, and allows the AMP-04 to offer gain nonlinearity of $0.005 \%$ and a gain tempco of $30 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$.
A proprietary input structure limits input offset currents to less than 5 nA with drift of only $8 \mathrm{pA} /{ }^{\circ} \mathrm{C}$, allowing direct connection of the AMP-04 to high impedance transducers and other signal sources.

[^210]FUNCTIONAL BLOCK DIAGRAM


The AMP-04 is specified over the extended industrial $\left(-40^{\circ} \mathrm{C}\right.$ to $+85^{\circ} \mathrm{C}$ ) temperature range. AMP-04s are available in plastic and ceramic DIP plus SO-8 surface mount packages.
Contact your local sales office for MIL-STD-883 data sheet and availability.

## PIN CONNECTIONS

8-Lead Epoxy DIP
(P Suffix)


8-Lead Narrow-Body SO
(S Suffix)


## AMP04-SPECIFICATIONS

ELECTRICAL CHARACTERISTICS ${ }_{N_{s}}=+5, V_{\mathrm{cm}}=+25, \mathrm{~T}_{\mathrm{n}}=+255^{\circ}$ uness ontemisise noted)

\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Parameter} \& \multirow[b]{2}{*}{Symbol} \& \multirow[b]{2}{*}{Conditions} \& \multicolumn{3}{|c|}{AMP-04E} \& \multicolumn{3}{|c|}{AMP-04F} \& \multirow[b]{2}{*}{Units} \\
\hline \& \& \& Min \& Typ \& Max \& Min \& Typ \& Max \& \\
\hline OFFSET VOLTAGE Input Offset Voltage Input Offset Voltage Drift Output Offset Voltage Output Offset Voltage Drift \& \begin{tabular}{l}
\(\mathrm{V}_{\mathrm{IOS}}\) \\
\(\mathrm{TCV}_{\text {Ios }}\) \\
\(\mathrm{V}_{\mathrm{oos}}\) \\
\(\mathrm{TCV}_{\text {oos }}\)
\end{tabular} \& \[
\begin{aligned}
\& -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\
\& -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}
\end{aligned}
\] \& \& \[
30
\]
\[
0.5
\] \& \[
\begin{aligned}
\& 150 \\
\& 300 \\
\& 3 \\
\& 1.5 \\
\& 3 \\
\& 30
\end{aligned}
\] \& \& \& \[
\begin{aligned}
\& 300 \\
\& 600 \\
\& 6 \\
\& 3 \\
\& 6 \\
\& 50
\end{aligned}
\] \& \begin{tabular}{l}
\(\mu \mathrm{V}\) \\
\(\mu \mathrm{V}\) \\
\(\mu \mathrm{V} /{ }^{\circ} \mathrm{C}\) \\
mV \\
mV \\
\(\mu \mathrm{V} /{ }^{\circ} \mathrm{C}\)
\end{tabular} \\
\hline \begin{tabular}{l}
INPUT CURRENT \\
Input Bias Current \\
Input Bias Current Drift Input Offset Current Input Offset Current Drift
\end{tabular} \& \[
\begin{aligned}
\& \mathrm{I}_{\mathrm{B}} \\
\& \mathrm{TCI}_{\mathrm{B}} \\
\& \mathrm{I}_{\mathrm{OS}} \\
\& \mathrm{TCI}_{\mathrm{Os}}
\end{aligned}
\] \& \[
\begin{aligned}
\& -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\
\& -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}
\end{aligned}
\] \& \& \[
\begin{aligned}
\& 22 \\
\& 65 \\
\& 1 \\
\& 8
\end{aligned}
\] \& \[
\begin{aligned}
\& 30 \\
\& 50 \\
\& 5 \\
\& 10
\end{aligned}
\] \& \& 65 \& \[
\begin{aligned}
\& 40 \\
\& 60 \\
\& 10 \\
\& 15
\end{aligned}
\] \& nA nA \(\mathrm{pA} /{ }^{\circ} \mathrm{C}\) nA nA \(\mathrm{pA} /{ }^{\circ} \mathrm{C}\) \\
\hline \begin{tabular}{l}
INPUT \\
Common-Mode Input Resistance Differential Input Resistance Input Voltage Range Common-Mode Rejection \\
Common-Mode Rejection \\
Power Supply Rejection
\end{tabular} \& \begin{tabular}{l}
\(\mathrm{V}_{\mathrm{IN}}\) CMR \\
CMR \\
PSRR
\end{tabular} \& \[
\begin{aligned}
\& 0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CM}} \leq 3.0 \mathrm{~V} \\
\& \mathrm{G}=1 \\
\& \mathrm{G}=10 \\
\& \mathrm{G}=100 \\
\& \mathrm{G}=1000 \\
\& 0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CM}} \leq 2.5 \mathrm{~V} \\
\& -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\
\& \mathrm{G}=1 \\
\& \mathrm{G}=10 \\
\& \mathrm{G}=100 \\
\& \mathrm{G}=1000 \\
\& 4.0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{S}} \leq 12 \mathrm{~V} \\
\& -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\
\& \mathrm{G}=1 \\
\& \mathrm{G}=10 \\
\& \mathrm{G}=100 \\
\& \mathrm{G}=1000
\end{aligned}
\] \&  \& \[
\begin{aligned}
\& 4 \\
\& 4 \\
\& \\
\& 80 \\
\& 100 \\
\& 105 \\
\& 105
\end{aligned}
\] \& 3.0 \& \begin{tabular}{l}
0 \\
55 \\
75 \\
80 \\
80 \\
50 \\
70 \\
75 \\
75 \\
85 \\
95 \\
95 \\
95
\end{tabular} \& 4
4 \& 3.0 \& \begin{tabular}{l}
G \(\Omega\) \\
\(G \Omega\) \\
V \\
dB \\
dB \\
dB \\
dB \\
dB \\
dB \\
dB \\
dB \\
dB \\
dB \\
dB \\
dB
\end{tabular} \\
\hline \begin{tabular}{l}
GAIN (G \(=100 \mathrm{~K} / \mathrm{R}_{\mathrm{GAIN}}\) ) \\
Gain Equation Accuracy \\
Gain Range \\
Nonlinearity \\
Gain Temperature Coefficient
\end{tabular} \& \(G\)

$\Delta G / \Delta T$ \& $$
\begin{aligned}
& \mathrm{G}=1 \text { to } 100 \\
& \mathrm{G}=1 \text { to } 100 \\
& -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\
& \mathrm{G}=1000 \\
& \mathrm{G}=1, \mathrm{R}_{\mathrm{L}}=5 \mathrm{k} \Omega \\
& \mathrm{G}=10, \mathrm{R}_{\mathrm{L}}=5 \mathrm{k} \Omega \\
& \mathrm{G}=100, \mathrm{R}_{\mathrm{L}}=5 \mathrm{k} \Omega
\end{aligned}
$$ \& 1 \& 0.2

0.4
0.005
0.015
0.025

30 \& $$
\begin{aligned}
& 0.5 \\
& 0.8 \\
& 1000
\end{aligned}
$$ \& 1 \& 0.75

50 \& \[
$$
\begin{aligned}
& 0.75 \\
& 1.0 \\
& 1000
\end{aligned}
$$

\] \& | \% |
| :--- |
| \% |
| \% |
| V/V |
| \% |
| \% |
| \% |
| ppm $/{ }^{\circ} \mathrm{C}$ | <br>


\hline | OUTPUT |
| :--- |
| Output Voltage Swing High |
| Output Voltage Swing Low Output Current Limit | \& $\mathrm{V}_{\mathrm{OH}}$


$\mathrm{V}_{\mathrm{OL}}$ \& | $\begin{aligned} & \mathbf{R}_{\mathbf{L}}=2 \mathrm{k} \Omega \\ & \mathbf{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathbf{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \end{aligned}$ |
| :--- |
| Sink |
| Source | \& \[

$$
\begin{aligned}
& 4.0 \\
& 3.8
\end{aligned}
$$

\] \& | 4.2 |
| :--- |
| 30 |
| 15 | \& 2.0 \& \[

$$
\begin{aligned}
& 4.0 \\
& 3.8
\end{aligned}
$$

\] \& \[

$$
\begin{aligned}
& 30 \\
& 15
\end{aligned}
$$

\] \& 2.5 \& | V |
| :--- |
| V |
| mV |
| mA |
| mA | <br>

\hline
\end{tabular}

| Parameter | Symbol | Conditions | AMP-04E |  |  | AMP-04F |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max | Min | Typ | Max |  |
| NOISE <br> Noise Voltage Density, RTI | $\mathrm{e}_{\mathrm{N}}$ |  |  |  |  |  |  |  |  |
|  |  | $\mathrm{f}=1 \mathrm{kHz}, \mathrm{G}=1$ |  | 270 |  |  | 270 |  | $\mathrm{nV} / \sqrt{\text { Hz }}$ |
|  |  | $\mathrm{f}=1 \mathrm{kHz}, \mathrm{G}=10$ |  | 45 |  |  | 45 |  | $\mathrm{nV} / \sqrt{\text { Hz }}$ |
|  |  | $\mathrm{f}=100 \mathrm{~Hz}, \mathrm{G}=100$ |  | 30 |  |  | 30 |  | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
|  | $\mathrm{i}_{\mathrm{N}}$ | $\mathrm{f}=100 \mathrm{~Hz}, \mathrm{G}=1000$ |  | 25 |  |  | 25 |  | $\mathrm{nV} / \sqrt{\overline{\mathrm{Hz}}}$ |
| Noise Current Density, RTI |  | $\mathrm{f}=100 \mathrm{~Hz}, \mathrm{G}=100$ |  | 4 |  |  | 4 |  | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
| Input Noise Voltage | $\mathrm{e}_{\mathrm{N}} \mathrm{p}-\mathrm{p}$ | 0.1 to $10 \mathrm{~Hz}, \mathrm{G}=1$ |  | 7 |  |  | 7 |  | $\mu \mathrm{V}$ p-p |
|  |  | 0.1 to $10 \mathrm{~Hz}, \mathrm{G}=10$ |  | 1.5 |  |  | 1.5 |  | $\mu \mathrm{V}$ p-p |
|  |  | 0.1 to $10 \mathrm{~Hz}, \mathrm{G}=100$ |  | 0.7 |  |  | 0.7 |  | $\mu \vee \mathrm{p}-\mathrm{p}$ |
| DYNAMIC RESPONSE Small Signal Bandwidth | BW | $\mathrm{G}=1,-3 \mathrm{~dB}$ |  | 300 |  |  | 300 |  | kHz |
| POWER SUPPLY <br> Supply Current | $\mathrm{I}_{\text {SY }}$ | $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ |  |  | $\begin{aligned} & 700 \\ & 850 \end{aligned}$ |  |  | $\begin{aligned} & 700 \\ & 850 \end{aligned}$ | $\begin{aligned} & \mu \mathrm{A} \\ & \mu \mathrm{~A} \end{aligned}$ |

Specifications subject to change without notice.

ELECTRICAL SPECIFICATIONS $\left(v_{S}= \pm 15 \mathrm{~V}, \mathrm{v}_{\mathrm{CM}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right.$ unless otherwise noted)


| Parameter | Symbol | Conditions | AMP-04E |  |  | AMP-04F |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max | Min | Typ | Max |  |
| GAIN (G $=100 \mathrm{~K} / \mathrm{R}_{\mathrm{GAIN}}$ ) Gain Equation Accuracy <br> Gain Range Nonlinearity <br> Gain Temperature Coefficient | G $\Delta \mathrm{G} / \Delta \mathrm{T}$ | $\begin{aligned} & \mathrm{G}=1 \text { to } 100 \\ & \mathrm{G}=1000 \\ & \mathrm{G}=1 \text { to } 100 \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathrm{G}=1, \mathrm{R}_{\mathrm{L}}=5 \mathrm{k} \Omega \\ & \mathrm{G}=10, \mathrm{R}_{\mathrm{L}}=5 \mathrm{k} \Omega \\ & \mathrm{G}=100, \mathrm{R}_{\mathrm{L}}=5 \mathrm{k} \Omega \end{aligned}$ | 1 | $\begin{aligned} & 0.2 \\ & 0.4 \\ & \\ & \\ & 0.005 \\ & 0.015 \\ & 0.025 \\ & 30 \end{aligned}$ | $\begin{aligned} & 0.5 \\ & \\ & 0.8 \\ & 1000 \end{aligned}$ | 1 | $\begin{aligned} & 0.75 \\ & \\ & \\ & 0.005 \\ & 0.015 \\ & 0.025 \\ & 50 \end{aligned}$ | $\begin{aligned} & 0.75 \\ & \\ & 1.0 \\ & 1000 \end{aligned}$ | $\begin{aligned} & \% \\ & \% \\ & \% \\ & \% \\ & \mathrm{~V} / \mathrm{V} \\ & \% \\ & \% \\ & \% \\ & \mathrm{ppm} /{ }^{\circ} \mathrm{C} \end{aligned}$ |
| OUTPUT <br> Output Voltage Swing High <br> Output Voltage Swing Low <br> Output Current Limit | $\begin{aligned} & \mathrm{V}_{\mathrm{OH}} \\ & \mathrm{~V}_{\mathrm{OL}} \end{aligned}$ | $\begin{aligned} & \mathbf{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & \mathbf{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & \mathbf{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \end{aligned}$ <br> Sink <br> Source | $\begin{aligned} & +13 \\ & +12.5 \end{aligned}$ | $+13.4$ $30$ $15$ | $-14.5$ | $\begin{aligned} & +13 \\ & +12.5 \end{aligned}$ | $\begin{aligned} & 30 \\ & 15 \end{aligned}$ | $-14.5$ | V <br> V <br> V <br> mA <br> mA |
| NOISE <br> Noise Voltage Density, RTI <br> Noise Current Density, RTI Input Noise Voltage | $\begin{aligned} & \mathrm{e}_{\mathrm{N}} \\ & \mathrm{i}_{\mathrm{N}} \\ & \mathrm{e}_{\mathrm{N}} \mathrm{p}-\mathrm{p} \\ & \mathrm{e}_{\mathrm{N}} \mathrm{p}-\mathrm{p} \\ & \mathrm{e}_{\mathrm{N}} \mathrm{p}-\mathrm{p} \end{aligned}$ | $\begin{aligned} & \mathrm{f}=1 \mathrm{kHz}, \mathrm{G}=1 \\ & \mathrm{f}=1 \mathrm{kHz}, \mathrm{G}=10 \\ & \mathrm{f}=100 \mathrm{~Hz}, \mathrm{G}=100 \\ & \mathrm{f}=100 \mathrm{~Hz}, \mathrm{G}=1000 \\ & \mathrm{f}=100 \mathrm{~Hz}, \mathrm{G}=100 \\ & 0.1 \text { to } 10 \mathrm{~Hz}, \mathrm{G}=1 \\ & 0.1 \text { to } 10 \mathrm{~Hz}, \mathrm{G}=10 \\ & 0.1 \text { to } 10 \mathrm{~Hz}, \mathrm{G}=100 \end{aligned}$ |  | $\begin{aligned} & 270 \\ & 45 \\ & 30 \\ & 25 \\ & 4 \\ & 5 \\ & 1 \\ & 0.5 \end{aligned}$ |  |  | $\begin{aligned} & 270 \\ & 45 \\ & 30 \\ & 25 \\ & 4 \\ & 5 \\ & 1 \\ & 0.5 \end{aligned}$ |  | $\begin{aligned} & \mathrm{nV} / \sqrt{\mathrm{Hz}} \\ & \mathrm{nV} / \sqrt{\mathrm{Hz}} \\ & \mathrm{nV} / \sqrt{\mathrm{Hz}} \\ & \mathrm{nV} / \sqrt{\mathrm{Hz}} \\ & \mathrm{pA} / \sqrt{\mathrm{Hz}} \\ & \mu V \mathrm{p}-\mathrm{p} \\ & \mu \mathrm{~V} \text { p-p } \\ & \mu \mathrm{V} \text { p-p } \end{aligned}$ |
| DYNAMIC RESPONSE Small Signal Bandwidth | BW | $\mathrm{G}=1,-3 \mathrm{~dB}$ | 700 |  |  |  | 700 |  | kHz |
| POWER SUPPLY <br> Supply Current | $\begin{aligned} & \mathrm{I}_{\mathrm{SY}} \\ & \mathrm{I}_{\mathrm{SY}} \end{aligned}$ | $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ |  | 750 | $\begin{aligned} & 900 \\ & 1100 \end{aligned}$ |  |  | $\begin{aligned} & 900 \\ & 1100 \end{aligned}$ | $\begin{aligned} & \mu \mathrm{A} \\ & \mu \mathrm{~A} \end{aligned}$ |

Specifications subject to change without notice.
WAFER TEST LIMITS $\left(\mathrm{V}_{\mathrm{s}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{cm}}=+2.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right.$ unless otherwise noted)

| Parameter | Symbol | Conditions | Limit | Units |
| :---: | :---: | :---: | :---: | :---: |
| OFFSET VOLTAGE Input Offset Voltage Output Offset Voltage | $\mathrm{V}_{\text {ios }}$ <br> $\mathrm{V}_{\mathrm{oos}}$ |  | $\begin{aligned} & 300 \\ & 3 \end{aligned}$ | $\mu V$ max mV max |
| INPUT CURRENT Input Bias Current Input Offset Current | $\begin{aligned} & \mathrm{I}_{\mathrm{B}} \\ & \mathrm{I}_{\mathrm{OS}} \end{aligned}$ |  | $\begin{aligned} & 40 \\ & 10 \end{aligned}$ | $n A \max$ nA max |
| INPUT <br> Common-Mode Rejection <br> Common-Mode Rejection | CMR CMR | $\begin{aligned} & 0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CM}} \leq 3.0 \mathrm{~V} \\ & \mathrm{G}=1 \\ & \mathrm{G}=10 \\ & \mathrm{G}=100 \\ & \mathrm{G}=1000 \\ & \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V},-12 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CM}} \leq+12 \mathrm{~V} \\ & \mathrm{G}=1 \\ & \mathrm{G}=10 \\ & \mathrm{G}=100 \end{aligned}$ | $\begin{aligned} & 55 \\ & 75 \\ & 80 \\ & 80 \\ & \\ & 55 \\ & 75 \\ & 80 \end{aligned}$ | dB min dB min dB min dB min <br> dB min dB min dB min |


| Parameter | Symbol | Conditions | Limit | Units |
| :---: | :---: | :---: | :---: | :---: |
| Power Supply Rejection | PSRR | $\begin{aligned} & \mathrm{G}=1000 \\ & 4.0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{s}} \leq 12 \mathrm{~V} \\ & \mathrm{G}=1 \\ & \mathrm{G}=10 \\ & \mathrm{G}=100 \\ & \mathrm{G}=1000 \end{aligned}$ | $\begin{aligned} & 80 \\ & 85 \\ & 95 \\ & 95 \\ & 95 \end{aligned}$ | dB min <br> dB min dB min dB min dB min |
| GAIN (G $=100 \mathrm{~K} / \mathrm{R}_{\text {GAIN }}$ ) Gain Equation Accuracy |  | $\mathrm{G}=1$ to 100 | 0.75 | \% max |
| OUTPUT <br> Output Voltage Swing High Output Voltage Swing Low | $\begin{aligned} & \mathrm{V}_{\mathrm{OH}} \\ & \mathrm{v}_{\mathrm{OL}} \end{aligned}$ | $\begin{aligned} & \mathbf{R}_{\mathbf{L}}=2 \mathrm{k} \Omega \\ & \mathbf{R}_{\mathbf{L}}=2 \mathrm{k} \Omega \end{aligned}$ | $\begin{aligned} & 4.0 \\ & 2.5 \end{aligned}$ | V min mV max |
| POWER SUPPLY <br> Supply Current | $\mathrm{I}_{\text {SY }}$ | $\mathrm{V}_{\mathrm{S}}= \pm 15$ | $\begin{aligned} & 900 \\ & 700 \end{aligned}$ | $\mu \mathrm{A}$ max $\mu \mathrm{A}$ max |

## NOTE

Electrical tests and wafer probe to the limits shown. Due to variations in assembly methods and normal yield loss, yield after packaging is not guaranteed for standard product dice. Consult factory to negotiate specifications based on dice lot qualifications through sample lot assembly and testing.

## ABSOLUTE MAXIMUM RATINGS ${ }^{\mathbf{1}}$

| Supply Voltage |  |
| :---: | :---: |
| Common-Mode Input Voltage ${ }^{2}$ | $\pm 18 \mathrm{~V}$ |
| Differential Input Voltage | 36 V |
| Output Short-Circuit Duration to GND | Indefinite |
| Storage Temperature Range |  |
| Z Package | $-65^{\circ} \mathrm{C}$ to $+175^{\circ} \mathrm{C}$ |
| P, S Package | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Operating Temperature Range |  |
| AMP-04A | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| AMP-04E, F | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Junction Temperature Range |  |
| Z Package | $-65^{\circ} \mathrm{C}$ to $+175^{\circ} \mathrm{C}$ |
| P, S Package | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Lead Temperature Range (Soldering, 6 | $+300^{\circ} \mathrm{C}$ |


| Package Type | $\boldsymbol{\theta}_{\mathbf{J A}}{ }^{\mathbf{3}}$ | $\boldsymbol{\theta}_{\mathbf{J C}}$ | Units |
| :--- | :---: | :---: | :---: |
| 8-Pin Cerdip (Z) | 148 | 16 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin Plastic DIP (P) | 103 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin SOIC (S) | 158 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTES

${ }^{1}$ Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
${ }^{2}$ For supply voltages less than $\pm 18 \mathrm{~V}$, the absolute maximum input voltage is equal to the supply voltage.
${ }^{3} \theta_{\mathrm{JA}}$ is specified for the worst case conditions, i.e., $\theta_{\mathrm{JA}}$ is specified for device in socket for cerdip, P-DIP, and LCC packages; $\theta_{\mathrm{JA}}$ is specified for device soldered in circuit board for SOIC package.

DICE CHARACTERISTICS


AMP-04 Die Size $0.075 \times 0.99$ inch, 7,425 sq. mils. Substrate (Die Backside) Is Connected to V+. Transistor Count, 81.

ORDERING GUIDE

| Model | Temperature <br> Range | $\mathbf{V}_{\mathbf{o s}} @+\mathbf{5} \mathbf{V}$ <br> $\mathbf{T}_{\mathbf{A}}=+\mathbf{2 5} 5^{\circ} \mathrm{C}$ | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- | :--- |
| AMP04EP | XIND | $150 \mu \mathrm{~V}$ | Plastic DIP | N-8 |
| AMP04FP | XIND | $300 \mu \mathrm{~V}$ | Plastic DIP | N-8 |
| AMP04FS | XIND | $300 \mu \mathrm{~V}$ | SOIC | SO-8 |
| AMP04AZ | MIL | Note 2 | Cerdip | Q-8 |
| AMP04GBC | $+25^{\circ} \mathrm{C}$ | $300 \mu \mathrm{~V}$ |  |  |

## NOTES

${ }^{1}$ For outline information see Package Information section.
${ }^{2}$ Consult MIL-STD-883 data sheet.

## APPLICATIONS

## Common-Mode Rejection

The purpose of the instrumentation amplifier is to amplify the difference between the two input signals while ignoring offset and noise voltages common to both inputs. One way of judging the device's ability to reject this offset is the common-mode gain, which is the ratio between a change in the common-mode voltage and the resulting output voltage change. Instrumentation amplifiers are often judged by the common-mode rejection ratio, which is equal to $20 \times \log _{10}$ of the ratio of the user-selected differential signal gain to the common-mode gain, commonly called the CMRR. The AMP-04 offers excellent CMRR, guaranteed to be greater than 90 dB at gains of 100 or greater. Input offsets attain very low temperature drift by proprietary laser-trimmed thin-film resistors and high gain amplifiers.

## Input Common-Mode Range Includes Ground

The AMP-04 employs a patented topology (Figure 1) that uniquely allows the common-mode input voltage to truly extend to zero volts where other instrumentation amplifiers fail. To illustrate, take for example the single supply, gain of 100 instrumentation amplifier as in Figure 2. As the inputs approach zero volts, in order for the output to go positive, amplifier A's output ( $\mathrm{V}_{\mathrm{OA}}$ ) must be allowed to go below ground, to -0.094 volts. Clearly this is not possible in a single supply environment. Consequently this instrumentation amplifier configuration's input common-mode voltage cannot go below about 0.4 volts. In comparison, the AMP-04 has no such restriction. Its inputs will function with a zero-volt common-mode voltage.


Figure 1. Functional Block Diagram


Figure 2. Gain $=100$ Instrumentation Amplifier

## Input Common-Mode Voltage Below Ground

Although not tested and guaranteed, the AMP-04 inputs are biased in a way that they can amplify signals linearly with common-mode voltage as low as -0.25 volts below ground. This holds true over the industrial temperature range from $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.

## Extended Positive Common-Mode Range

On the high side, other instrumentation amplifier configurations, such as the three op amp instrumentation amplifier, can have severe positive common-mode range limitations. Figure 3 shows an example of a gain of 1001 amplifier, with an input common-mode voltage of 10 volts. For this circuit to function, $\mathrm{V}_{\mathrm{OB}}$ must swing to 15.01 volts in order for the output to go to 10.01 volts. Clearly no op amp can handle this swing range (given a +15 V supply) as the output will saturate long before it reaches the supply rails. Again the AMP-04's topology does not have this limitation. Figure 4 illustrates the AMP-04 operating at the same common-mode conditions as in Figure 3. None of the internal nodes has a signal high enough to cause amplifier saturation. As a result, the AMP-04 can accommodate much wider common-mode range than most instrumentation amplifiers.


Figure 3. Gain $=$ 1001, Three Op Amp Instrumentation Amplifier


Figure 4. Gain $=1000$, AMP-04

## Programming the Gain

The gain of the AMP-04 is programmed by the user by selecting a single external resistor- $\mathrm{R}_{\mathrm{GAIN}}$ :

$$
\text { Gain }=100 k \Omega / R_{G A I N}
$$

The output voltage is then defined as the differential input voltage times the gain.

$$
\mathrm{V}_{\mathrm{OUT}}=\left(\mathrm{V}_{\mathrm{IN}+}-\mathrm{V}_{\mathrm{IN}-}\right) \times \text { Gain }
$$

In single supply systems, offsetting the ground is often desired for several reasons. Ground may be offset from zero to provide a quieter signal reference point, or to offset "zero" to allow a unipolar signal range to represent both positive and negative values.
In noisy environments such as those having digital switching, switching power supplies or externally generated noise, ground may not be the ideal place to reference a signal in a high accuracy system.
Often, real world signals such as temperature or pressure may generate voltages that are represented by changes in polarity. In a single supply system the signal input cannot be allowed to go below ground, and therefore the signal must be offset to accommodate this change in polarity. On the AMP-04, a reference input pin is provided to allow offsetting of the input range.
The gain equation is more accurately represented by including this reference input.

$$
V_{O U T}=\left(V_{I N+}-V_{I N-}\right) \times \text { Gain }+V_{R E F}
$$

## Grounding

The most common problems encountered in high performance analog instrumentation and data acquisition system designs are found in the management of offset errors and ground noise. Primarily, the designer must consider temperature differentials and thermocouple effects due to dissimilar metals, IR voltage drops, and the effects of stray capacitance. The problem is greatly compounded when high speed digital circuitry, such as that accompanying data conversion components, is brought into the proximity of the analog section. Considerable noise and error contributions such as fast-moving logic signals that easily propagate into sensitive analog lines, and the unavoidable noise common to digital supply lines must all be dealt with if the accuracy of the carefully designed analog section is to be preserved.
Besides the temperature drift errors encountered in the amplifier, thermal errors due to the supporting discrete components should be evaluated. The use of high quality, low-TC components where appropriate is encouraged. What is more important, large thermal gradients can create not only unexpected changes in component values, but also generate significant thermoelectric voltages due to the interface between dissimilar metals such as lead solder, copper wire, gold socket contacts, Kovar lead frames, etc. Thermocouple voltages developed at these junctions commonly exceed the TCV ${ }_{\text {os }}$ contribution of the AMP-04. Component layout that takes into account the power dissipation at critical locations in the circuit and minimizes gradient effects and differential common-mode voltages by taking advantage of input symmetry will minimize many of these errors.
High accuracy circuitry can experience considerable error contributions due to the coupling of stray voltages into sensitive areas, including high impedance amplifier inputs which benefit from such techniques as ground planes, guard rings, and shields. Careful circuit layout, including good grounding and signal rout-
ing practice to minimize stray coupling and ground loops is recommended. Leakage currents can be minimized by using high quality socket and circuit board materials, and by carefully cleaning and coating complete board assemblies.
As mentioned above, the high speed transition noise found in logic circuitry is the sworn enemy of the analog circuit designer. Great care must be taken to maintain separation between them to minimize coupling. A major path for these error voltages will be found in the power supply lines. Low impedance, load related variations and noise levels that are completely acceptable in the high thresholds of the digital domain make the digital supply unusable in nearly all high performance analog applications. The user is encouraged to maintain separate power and ground between the analog and digital systems wherever possible, joining only at the supply itself if necessary, and to observe careful grounding layout and bypass capacitor scheduling in sensitive areas.

## Input Shield Drivers

High impedance sources and long cable runs from remote transducers in noisy industrial environments commonly experience significant amounts of noise coupled to the inputs. Both stray capacitance errors and noise coupling from external sources can be minimized by running the input signal through shielded cable. The cable shield is often grounded at the analog input common, however improved dynamic noise rejection and a reduction in effective cable capacitance is achieved by driving the shield with a buffer amplifier at a potential equal to the voltage seen at the input. Driven shields are easily realized with the AMP-04. Examination of the simplified schematic shows that the potentials at the gain set resistor pins of the AMP-04 follow the inputs precisely. As shown in Figure 5, shield drivers are easily realized by buffering the potential at these pins by a dual, single supply op amp such as the OP-213. Alternatively, applications with single-ended sources or that use twisted-pair cable could drive a single shield. To minimize error contributions due to this additional circuitry, all components and wiring should remain in proximity to the AMP-04 and careful grounding and bypassing techniques should be observed.


Figure 5. Cable Shield Drivers

## Compensating for Input and Output Errors

To achieve optimal performance, the user needs to take into account a number of error sources found in instrumentation amplifiers. These consist primarily of input and output offset voltages and leakage currents.
The input and output offset voltages are independent from one another, and must be considered separately. The input offset component will of course be directly multiplied by the gain of the amplifier, in contrast to the output offset voltage that is independent of gain. Therefore, the output error is the dominant factor at low gains, and the input error grows to become the greater problem as gain is increased. The overall equation for offset voltage error referred to the output (RTO) is:

$$
V_{O S}(R T O)=\left(V_{I O S} \times G\right)+V_{O O S}
$$

where $V_{I O S}$ is the input offset voltage and $V_{O O S}$ the output offset voltage, and $G$ is the programmed amplifier gain.

The change in these error voltages with temperature must also be taken into account. The specification $\mathrm{TCV}_{\mathrm{OS}}$, referred to the output, is a combination of the input and output drift specifications. Again, the gain influences the input error but not the output, and the equation is:

$$
T C V_{O S}(R T O)=\left(T C V_{I O S} \times G\right)+T C V_{O O S}
$$

In some applications the user may wish to define the error contribution as referred to the input, and treat it as an input error. The relationship is:

$$
\mathrm{TCV}_{\mathrm{OS}}(\mathrm{RTI})=\mathrm{TCV}_{\mathrm{IOs}}+\left(\mathrm{TCV}_{\mathrm{OOS}} / \mathrm{G}\right)
$$

The bias and offset currents of the input transistors also have an impact on the overall accuracy of the input signal. The input leakage, or bias currents of both inputs will generate an additional offset voltage when flowing through the signal source resistance. Changes in this error component due to variations with signal voltage and temperature can be minimized if both input source resistances are equal, reducing the error to a common-mode voltage which can be rejected. The difference in bias current between the inputs, the offset current, generates a differential error voltage across the source resistance that should be taken into account in the user's design.
In applications utilizing floating sources such as thermocouples, transformers, and some photo detectors, the user must take care to provide some current path between the high impedance inputs and analog ground. The input bias currents of the AMP04 , although extremely low, will charge the stray capacitance found in nearby circuit traces, cables, etc., and cause the input to drift erratically or to saturate unless given a bleed path to the analog common. Again, the use of equal resistance values will create a common input error voltage that is rejected by the amplifier.

## Reference Input

The $\mathrm{V}_{\text {REF }}$ input is used to set the system ground. For dual supply operation it can be connected to ground to give zero volts out with zero volts differential input. In single supply systems it could be connected either to the negative supply or to a pseudoground between the supplies. In any case, the REF input must be driven with low impedance.

## Noise Filtering

Unlike most previous instrumentation amplifiers, the output stage's inverting input (Pin 8) is accessible. By placing a capacitor across the AMP-04's feedback path (Figure 6, Pins 6 and 8)


Figure 6. Noise Band Limiting
a single-pole low-pass filter is produced. The cutoff frequency ( $f_{\text {LP }}$ ) follows the relationship:

$$
f_{L P^{P}}=\frac{1}{2 \pi(100 k \Omega) C_{e x t}}
$$

Filtering can be applied to reduce wide band noise. Figure 7a shows a 10 Hz low-pass filter, gain of 1000 for the AMP-04. Figures 7 b and 7 c illustrate the effect of filtering on noise. The photo in Figure 7b shows the output noise before filtering. By adding a $0.15 \mu \mathrm{~F}$ capacitor, the noise is reduced by about a factor of 4 as shown in Figure 7c.


Figure 7a. 10 Hz Low-Pass Filter


Figure 7b. Unfiltered AMP-04 Output


Figure 7c. 10 Hz Low-Pass Filtered Output

## Power Supply Considerations

In dual supply applications (for example $\pm 15 \mathrm{~V}$ ) if the input is connected to a low resistance source less than $100 \Omega$, a large current may flow in the input leads if the positive supply is applied before the negative supply during power-up. A similar condition may also result upon a loss of the negative supply. If these conditions could be present in you system, it is recommended that a series resistor up to $1 \mathrm{k} \Omega$ be added to the input leads to limit the input current.

This condition can not occur in a single supply environment as losing the negative supply effectively removes any current return path.

## Offset Nulling in Dual Supply

Offset may be nulled by feeding a correcting voltage at the $\mathrm{V}_{\text {REF }}$ pin (Pin 5). However, it is important that the pin be driven with a low impedance source. Any measurable resistance will degrade the amplifier's common-mode rejection performance as well as its gain accuracy. An op amp may be used to buffer the offset null circuit as in Figure 8.


Figure 8. Offset Adjust for Dual Supply Applications

## Offset Nulling in Single Supply

Nulling the offset in single supply systems is difficult because the adjustment is made to try to attain zero volts. At zero volts out, the output is in saturation (to the negative rail) and the output voltage is indistinguishable from the normal offset error. Consequently the offset nulling circuit in Figure 9 must be used with caution.

First, the potentiometer should be adjusted to cause the output to swing in the positive direction; then adjust it in the reverse direction, causing the output to swing toward ground, until the output just stops changing. At that point the output is at the saturation limit.


Figure 9. Offset Adjust for Single Supply Applications

## Alternative Nulling Method

An alternative null correction technique is to inject an offset current into the summing node of the output amplifier as in Figure 10. This method does not require an external op amp. However the drawback is that the amplifier will move off its null as the input common-mode voltage changes. It is a less desirable nulling circuit than the previous method.


Figure 10. Current Injection Offsetting Is Not Recommended

## APPLICATION CIRCUITS

## Low Power Precision Single Supply RTD Amplifier

Figure 11 shows a linearized RTD amplifier that is powered off a single +5 volt supply. However, the circuit will work up to 36 volts without modification. The RTD is excited by a $100 \mu \mathrm{~A}$ constant current that is regulated by amplifier A (OP-295). The 0.202 volts reference voltage used to generate the constant current is divided down from the 2.500 volt reference. The AMP04 amplifies the bridge output to a $10 \mathrm{mV} /{ }^{\circ} \mathrm{C}$ output coefficient.


Figure 11. Precision Single Supply RTD Thermometer Amplifier

The RTD is linearized by feeding a portion of the signal back to the reference circuit, increasing the reference voltage as the temperature increases. When calibrated properly, the RTD's nonlinearity error will be canceled.

To calibrate, either immerse the RTD into a zero-degree ice bath or substitute an exact $100 \Omega$ resistor in place of the RTD. Then adjust bridge BALANCE potentiometer R3 for a 0 volt output. Note that a 0 volt output is also the negative output swing limit of the AMP-04 powered with a single supply. Therefore, be sure to adjust R3 to first cause the output to swing positive and then back off until the output just stop swinging negatively.
Next, set the LINEARITY ADJ. potentiometer to the midrange. Substitute an exact $247.04 \Omega$ resistor (equivalent to $400^{\circ} \mathrm{C}$ temperature) in place of the RTD. Adjust the FULL-SCALE potentiometer for a 4.000 volts output.
Finally substitute a $175.84 \Omega$ resistor (equivalent to $200^{\circ} \mathrm{C}$ temperature), and adjust the LINEARITY ADJ potentiometer for a 2.000 volts at the output. Repeat the full-scale and the half-scale adjustments as needed.
When properly calibrated, the circuit achieves better than $\pm 0.5^{\circ} \mathrm{C}$ accuracy within a temperature measurement range from $0^{\circ} \mathrm{C}$ to $400^{\circ} \mathrm{C}$.

## Precision 4-20mA Loop Transmitter With Noninteractive Trim

Figure 12 shows a full bridge strain gage transducer amplifier circuit that is powered off the $4-20 \mathrm{~mA}$ current loop. The AMP-04 amplifies the bridge signal differentially and is converted to a current by the output amplifier. The total quiescent current drawn by the circuit, which includes the bridge, the amplifiers, and the resistor biasing, is only a fraction of the 4 mA null current that flows through the current-sense resistor
$\mathrm{R}_{\text {SENSE }}$. The voltage across $\mathrm{R}_{\text {SENSE }}$ feeds back to the OP-90's input, whose common-mode is fixed at the current summing reference voltage, thus regulating the output current.
With no bridge signal, the 4 mA null is simply set up by the $50 \mathrm{k} \Omega$ NULL potentiometer plus the $976 \mathrm{k} \Omega$ resistors that inject an offset that forces an 80 mV drop across $\mathbf{R}_{\text {SENSE }}$. At a 50 mV full-scale bridge voltage, the AMP-04 amplifies the voltage-to-current converter for a full-scale of 20 mA at the output. Since the OP-90's input operates at a constant 0 volt common-mode voltage, the null and the span adjustments do


Figure 12. Precision 4-20 mA Loop Transmitter Features Noninteractive Trims
not interact with one another. Calibration is simple and easy with the NULL adjusted first, followed by SPAN adjust. The entire circuit can be remotely placed, and powered from the 4-20 mA 2-wire loop.

## 4-20 mA Loop Receiver

At the receiving end of a $4-20 \mathrm{~mA}$ loop, the AMP- 04 makes a convenient differential receiver to convert the current back to a usable voltage (Figure 13). The $4-20 \mathrm{~mA}$ signal current passes through a $100 \Omega$ sense resistor. The voltage drop is differentially amplified by the AMP-04. The 4 mA offset is removed by the offset correction circuit.


Figure 13. 4 to 20 mA Line Receiver

## Low Power, Pulsed Load-Cell Amplifier

Figure 14 shows a $350 \Omega$ load cell that is pulsed with a low duty cycle to conserve power. The OP-295's rail-to-rail output capability allows a maximum voltage of 10 volts to be applied to the bridge. The bridge voltage is selectively pulsed on when a measurement is made. A negative-going pulse lasting 200 ms should be applied to the MEASURE input. The long pulse width is necessary to allow ample settling time for the long time constant of the low-pass filter around the AMP-04. A much faster settling time can be achieved by omitting the filter capacitor.


Figure 14. Pulsed Load Cell Bridge Amplifier

Single Supply Programmable Gain Instrumentation Amplifier Combining with the single supply ADG221 quad analog switch, the AMP-04 makes a useful programmable gain amplifier that can handle input and output signals at zero volts. Figure 15 shows the implementation. A logic low input to any of the gain control ports will cause the gain to change by shorting a gain-set resistor across AMP-04's Pins 1 and 8 . Trimming is required at higher gains to improve accuracy because the switch ON -resistance becomes a more significant part of the gain-set resistance. The gain of 500 setting has two switches connected in parallel to reduce the switch resistance.


Figure 15. Single Supply Programmable Gain Instrumentation Amplifier

The switch ON resistance is lower if the supply voltage is 12 volts or higher. Additionally the overall amplifier's temperature coefficient also improves with higher supply voltage.


Figure 16. Input Offset ( $V_{\text {Ios }}$ ) Distribution @+5V


Figure 18. Input Offset Drift (TCV ${ }_{10 \text { s }}$ ) Distribution @ +5 V


Figure 20. Output Offset ( $V_{o o s}$ ) Distribution @ +5 V


Figure 17. Input Offset ( $V_{10 s}$ ) Distribution @ $\pm 15$ V


Figure 19. Input Offset Drift (TCV ${ }_{10 s}$ ) Distribution @ $\pm 15$ V


Figure 21. Output Offset ( $V_{o o s}$ ) Distribution @ $\pm 15$ V


Figure 22. Output Offset Drift ( $T C V_{\text {Oos }}$ ) Distribution @ +5V


Figure 24. Output Voltage Swing vs. Temperature @ +5 V


Figure 26. Input Bias Current vs. Temperature


Figure 23. Output Offset Drift (TCV ${ }_{\text {Oos }}$ ) Distribution @ $\pm 15 \mathrm{~V}$


Figure 25. Output Voltage Swing vs. Temperature $@ \pm 15$ V


Figure 27. Input Offset Current vs. Temperature


Figure 28. Closed-Loop Voltage Gain vs. Frequency


Figure 30. Common-Mode Rejection vs. Frequency


Figure 32. Positive Power Supply Rejection vs. Frequency


Figure 29. Closed-Loop Output Impedance vs. Frequency


Figure 31. Common-Mode Rejection vs. Voltage Gain


Figure 33. Negative Power Supply Rejection vs. Frequency


Figure 34. Voltage Noise Density vs. Gain


Figure 36. Voltage Noise Density vs. Frequency


Figure 38. Supply Current vs. Temperature


Figure 35. Voltage Noise Density vs. Gain, $f=1 \mathrm{kHz}$



Figure 39. Maximum Output Voltage vs. Load Resistance
Selection Tree ..... 11-2
Selection Guide ..... 11-3
AD202/AD204 - Low Cost, Miniature Isolation Amplifiers ..... 11-5
AD210 - Precision, Wide Bandwidth, 3-Port Isolation Amplifier ..... 11-12

Selection Tree - Isolation Amplifiers


## Selection Guide—Isolation Amplifiers

| Model | Peak <br> Volt Iso <br> V pk | Gain <br> Range <br> V／V | Gain <br> Nonlin <br> \％max | Freq <br> Resp <br> $\mathbf{k H z}$ | Package Options ${ }^{1}$ | Temp Ranges ${ }^{2}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 289 | 2500 | 1－100 | 0．012－0．05 | 20 | Module | C |
| 290A | 1500 | 1－100 | 0．1－0．25 | 2.5 | Module | I |
| 292A | 1500 | 1－100 | 0．1－0．25 | 2.5 | Module | I |
| AD202 | 1000－2000 | 1－100 | 0．025－0．05 | 2 | $\mathrm{N}, \mathrm{Y}$ | C |
| AD203 | 2000 | 1－100 | 0.025 | 10 | N | M |
| AD204 | 1000－2000 | 1－100 | 0．025－0．05 | 5 | N，Y | I |
| AD208 | 1000－2000 | 1－1000 | 0．015－0．03 | $0.4-4 \mathrm{kHz}$ | Y | I |
| AD210 | 2500－3500 | 1－100 | 0．012－0．025 | 20 | N | I |


| Comments | Page $^{\mathbf{3}}$ |
| :--- | :--- |
| Precision，Wide Bandwidth，Synchronized | A 5－75 |
| Single Channel，General Purpose | A 5－81 |
| Multichannel，General Purpose | A 5－81 |
| Lowest Cost，Small Size，Single Channel | $11-5$ |
| Rugged，Military Temperature Range，Wide Bandwidth | A 5－19 |
| Lowest Cost，Small Size，Multichannel | $11-5$ |
| Precision，Low Cost，Single Channel，mV Input | A 5－41 |
| Precision，3－Port Isolation，Wide Bandwidth | $\mathbf{1 1 - 1 2}$ |

${ }^{1}$ Package Options：D＝Hermetic DIP，Ceramic or Metal；E＝Ceramic Leadless Chip Carrier；F＝Ceramic Flatpack；G＝Ceramic Pin Grid Array；H＝Hermetic Metal Can；J＝J－Leaded Ceramic Package； $M=$ Hermetic Metal Can DIP； $\mathbf{N}=$ Plastic or Epoxy Sealed DIP； $\mathbf{P}=$ Plastic Leaded Chip Carrier； $\mathbf{Q}=$ Cerdip； $\mathbf{R}=$ Small Outline＂SOIC＂Package；RS $=$ SSOP - Shrink Small Outline Package；$S=$ Plastic
 ${ }^{2}$ Temperature Ranges： $\mathrm{C}=$ Commercial， $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C} ; \mathrm{I}=$ Industrial，$-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$（Some older products $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ）； $\mathrm{M}=$ Military，$-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ ．If a device has military grade offerings，the M temperature designator will be followed by：／to indicate 883B，${ }_{\mathrm{J}}$ for JAN，${ }_{D}$ for SMD，and ${ }_{\mathrm{s}}$ for space level．
${ }^{3} \mathrm{~A}=$ Amplifier Reference Manual．All other entries refer to this volume．
Boldface Type：Data sheet information in this volume．

## FEATURES

## Small Size: 4 Channels/Inch

Low Power: 35mW (AD204)
High Accuracy: $\pm \mathbf{0} .025 \%$ max Nonlinearity (K Grade)
High CMR: 130dB (Gain = 100V/V)
Wide Bandwidth: 5kHz Full-Power (AD204)
High CMV Isolation: $\pm 2000 \mathrm{~V}$ pk Continuous (K Grade)
(Signal and Power)
Isolated Power Outputs
Uncommitted Input Amplifier

## APPLICATIONS

Multichannel Data Acquisition
Current Shunt Measurements
Motor Controls
Process Signal Isolation
High Voltage Instrumentation Amplifier

## GENERAL DESCRIPTION

The AD202 and AD204 are general purpose, two-port, trans-former-coupled isolation amplifiers that may be used in a broad range of applications where input signals must be measured, processed and/or transmitted without a galvanic connection. These industry standard isolation amplifiers offer a complete isolation function, with both signal and power isolation provided for in a single compact plastic SIP or DIP style package. The primary distinction between the AD202 and the AD204 is that the AD202 is powered directly from a +15 V dc supply while the AD204 is powered by an externally supplied clock, such as the recommended AD246 Clock Driver.

The AD202 and AD204 provide total galvanic isolation between the input and output stages of the isolation amplifier through the use of internal transformer-coupling. The functionally complete AD202 and AD204 eliminate the need for an external, user-supplied dc/dc converter. This permits the designer to minimize the necessary circuit overhead and consequently reduce the overall design and component costs.
The design of the AD202 and AD204 emphasizes maximum flexibility and ease of use, including the availability of an uncommitted op amp on the input stage. They feature a bipolar $\pm 5 \mathrm{~V}$ output range, an adjustable gain range of from 1 to $100 \mathrm{~V} / \mathrm{V}$, $\pm 0.025 \%$ max nonlinearity (K grade), 130 dB of CMR and the AD204 consumes a low 35 mW of power.

## PRODUCT HIGHLIGHTS

The AD202 and AD204 are full-featured isolators offering numerous benefits to the user:

Small Size: The AD202 and AD204 are available in SIP and DIP form packages. The SIP package is just $0.25^{\prime \prime}$ wide, giving the user a channel density of four channels per inch. The isolation barrier is positioned to maximize input to output spacing. For

## FUNCTIONAL BLOCK DIAGRAM


applications requiring a low profile, the DIP package provides a height of just $0.350^{\prime \prime}$.
High Accuracy: With a maximum nonlinearity of $\pm 0.025 \%$ for the AD202K/AD204K ( $\pm 0.05 \%$ for the AD202J/AD204J) and low drift over temperature, the AD202 and AD204 provide high isolation without loss of signal integrity.
Low Power: Power consumption of 35 mW (AD204) and 75 mW (AD202) over the full signal range makes these isolators ideal for use in applications with large channel counts or tight power budgets.
Wide Bandwidth: The AD204's full-power bandwidth of 5 kHz makes it useful for wideband signals. It is also effective in applications like control loops, where limited bandwidth could result in instability.
Excellent Common-Mode Performance: The AD202K/AD204K provide $\pm 2000 \mathrm{~V} \mathrm{pk}$ continuous common-mode isolation, while the AD202J/AD204J provide $\pm 1000 \mathrm{~V}$ pk continuous commonmode isolation. All models have a total common-mode input capacitance of less than 5 pF inclusive of power isolation. This results in CMR ranging from 130 dB at a gain of 100 to 104 dB (minimum at unity gain) and very low leakage current ( $2 \mu \mathrm{~A}$ maximum).
Flexible Input: An uncommitted op amp is provided at the input of all models. This provides buffering and gain as required, and facilitates many alternative input functions including filtering, summing, high-voltage ranges, and current (transimpedance) input.
Isolated Power: The AD204 can supply isolated power of $\pm 7.5 \mathrm{~V}$ at 2 mA . This is sufficient to operate a low-drift input preamp, provide excitation to a semiconductor strain gage, or to power any of a wide range of user-supplied ancillary circuits. The AD202 can supply $\pm 7.5 \mathrm{~V}$ at 0.4 mA which is sufficient to operate adjustment networks or low-power references and op amps, or to provide an open-input alarm.

[^211] complete data sheet, call our fax retrieval system at 1-800-446-6212.

| Model | AD204J | AD204K | AD202J | AD202K |
| :---: | :---: | :---: | :---: | :---: |
| GAIN <br> Range <br> Error <br> vs. Temperature <br> vs. Time <br> vs. Supply Voltage <br> Nonlinearity ( $\mathbf{G}=1 \mathrm{~V} / \mathrm{V})^{1}$ <br> Nonlinearity vs. Isolated Supply Load | $\begin{aligned} & 1 \mathrm{~V} / \mathrm{V}-100 \mathrm{~V} / \mathrm{V} \\ & \pm 0.5 \% \text { typ }( \pm 4 \% \text { max }) \\ & \pm 20 \mathrm{ppm} /{ }^{\circ} \mathrm{Ctyp}\left( \pm 45 \mathrm{ppm} /{ }^{\circ} \mathrm{C} \text { max }\right) \\ & \pm 50 \mathrm{ppm} / 1000 \mathrm{Hours} \\ & \pm 0.01 \% / \mathrm{V} \\ & \pm 0.05 \% \text { max } \\ & \pm 0.0015 \% / \mathrm{mA} \end{aligned}$ | $\begin{aligned} & \pm 0.01 \% / V \\ & \pm 0.025 \% \text { max } \end{aligned}$ | $\begin{aligned} & \star \\ & \star \\ & \pm 0.01 \% / V \\ & \pm 0.05 \% \text { max } \end{aligned}$ | $\begin{aligned} & \pm 0.01 \% / V \\ & \pm 0.025 \% \text { max } \end{aligned}$ |
| INPUT VOLTAGE RATINGS <br> Input Voltage Range <br> Max Isolation Voltage (Input to Output) <br> AC, 60 Hz , Continuous <br> Continuous (AC and DC) <br> Isolation-Mode Rejection Ratio (IMRR) $(\omega 60 \mathrm{~Hz}$ <br> $\mathbf{R}_{\mathbf{S}} \leq 100 \Omega(\mathrm{HI} \& \operatorname{LO}$ Inputs) $G=1 \mathrm{~V} / \mathrm{V}$ <br> $G=100 \mathrm{~V} / \mathrm{V}$ <br> $R_{S} \leq 1 \mathrm{k} \Omega$ (Input HI, LO, or Both) $\mathrm{G}=1 \mathrm{~V} / \mathrm{V}$ <br> $\mathrm{G}=100 \mathrm{~V} / \mathrm{V}$ <br> Leakage Current Input to Output (a 240 V rms, 60 Hz | $\begin{aligned} & \pm 5 \mathrm{~V} \\ & \\ & 750 \mathrm{~V} \text { rms } \\ & \pm 1000 \mathrm{~V} \text { peak } \\ & 110 \mathrm{~dB} \\ & 130 \mathrm{~dB} \\ & 104 \mathrm{~dB} \text { min } \\ & 110 \mathrm{~dB} \text { min } \\ & 2 \mu \mathrm{~A} \mathrm{rms} \mathrm{max} \end{aligned}$ | 1500 V rms $\pm 2000 \mathrm{~V}$ peak <br> 110 dB <br> 104 dB min | 750 V rms $\pm 1000 \mathrm{~V}$ peak <br> 105 dB <br> 100 dB min | 1500 V rms $\pm 2000 \mathrm{~V}$ peak <br> 105 dB <br> 100 dB min * <br> * |
| INPUT IMPEDANCE <br> Differential ( $\mathrm{G}=1 \mathrm{~V} / \mathrm{V}$ ) <br> Common Mode | $\begin{aligned} & 10^{12} \Omega \\ & 2 \mathrm{G} \Omega \\| 4.5 \mathrm{pF} \end{aligned}$ | * | * |  |
| INPUT BIASCURRENT Initial, $@+25^{\circ} \mathrm{C}$ vs. Temperature ( 0 to $+70^{\circ} \mathrm{C}$ ) | $\begin{aligned} & \pm 30 \mathrm{pA} \\ & \pm 10 \mathrm{nA} \end{aligned}$ | * | * |  |
| INPUT DIFFERENCECURRENT Initial, $\left(a+25^{\circ} \mathrm{C}\right.$ vs. Temperature ( 0 to $+70^{\circ} \mathrm{C}$ ) | $\begin{aligned} & \pm 5 \mathrm{pA} \\ & \pm 2 \mathrm{nA} \end{aligned}$ | * | * ${ }_{\text {* }}$ |  |
| INPUT NOISE Voltage, 0.1 to 100 Hz $\mathrm{f}>200 \mathrm{~Hz}$ | $\begin{aligned} & 4 \mu V \mathrm{p}-\mathrm{p} \\ & 50 \mathrm{nV} / \sqrt{\mathrm{Hz}} \end{aligned}$ | * | * |  |
| FREQUENCY RESPONSE <br> Bandwidth ( $\mathrm{V}_{\mathrm{O}} \leq 10 \mathrm{~V}$ p-p, $\mathrm{G}=1-50 \mathrm{~V} / \mathrm{V}$ ) <br> Settling Time, to $\pm 10 \mathrm{mV}$ ( 10 V Step) | $\begin{aligned} & 5 \mathrm{kHz} \\ & \mathrm{lms} \end{aligned}$ | $5 \mathrm{kHz}$ | $\underset{\star}{\mathbf{2 k H z}}$ | $\underset{\star}{2 \mathrm{kHz}}$ |
| ```OFFSET VOLTAGE(RTI) Initial, @ \(+25^{\circ} \mathrm{C}\) Adjustable to Zero vs. Temperature \(\left(0\right.\) to \(\left.+70^{\circ} \mathrm{C}\right)\)``` | $\begin{aligned} & ( \pm 15 \pm 15 / \mathrm{G}) \mathrm{mV} \text { max } \\ & \left( \pm 10 \pm \frac{10}{\mathrm{G}}\right) \mu \mathrm{V} /{ }^{\circ} \mathrm{C} \end{aligned}$ | $( \pm 5 \pm 5 / \mathrm{G}) \mathrm{mV} \max$ | $( \pm 15 \pm 15 / \mathrm{G}) \mathrm{mV} \text { max }$ | $( \pm 5 \pm 5 / \mathrm{G}) \mathrm{mV} \max$ |
| RATEDOUTPUT <br> Voltage (Out HI to Out LO) <br> Voltage at Out HI or Out LO (Ref. Pin 32) <br> Output Resistance <br> Output Ripple, 100 kHz Bandwidth 5 kHz Bandwidth | $\begin{aligned} & \pm 5 \mathrm{~V} \\ & \pm 6.5 \mathrm{~V} \\ & 3 \mathrm{k} \Omega \\ & 10 \mathrm{mV} \text { pk-pk } \\ & 0.5 \mathrm{mV} \mathrm{rms} \end{aligned}$ | $3 \mathrm{k} \Omega$ |  |  |
| ISOLATED POWER OUTPUT ${ }^{2}$ <br> Voltage, No Load <br> Accuracy <br> Current <br> Regulation, No Load to Full Load Ripple | $\begin{aligned} & \pm 7.5 \mathrm{~V} \\ & \pm 10 \% \\ & 2 \mathrm{~mA} \text { (Either Output }^{3} \\ & 5 \% \\ & 100 \mathrm{mV} \text { pk-pk } \end{aligned}$ | 2 mA (Either Output) ${ }^{3}$ | $400 \mu \mathrm{~A}$ Total | $400 \mu \mathrm{~A} \text { Total }$ |
| OSCILLATOR DRIVE INPUT <br> Input Voltage Input Frequency | 15V pk-pk nominal 25 kHz nominal | 15 V pk-pk nominal 25 kHz nominal | N/A <br> N/A | $\begin{aligned} & \text { N/A } \\ & \text { N/A } \end{aligned}$ |
| POWER SUPPLY (AD202 Only) <br> Voltage, Rated Performance <br> Voltage, Operating <br> Current, NoLoad ( $\mathrm{V}_{\mathrm{S}}=+15 \mathrm{~V}$ ) | $\begin{aligned} & \text { N/A } \\ & \text { N/A } \\ & \text { N/A } \end{aligned}$ | $\begin{aligned} & \text { N/A } \\ & \text { N/A } \\ & \text { N/A } \end{aligned}$ | $\begin{aligned} & +15 \mathrm{~V} \pm 5 \% \\ & +15 \mathrm{~V} \pm 10 \% \\ & 5 \mathrm{~mA} \end{aligned}$ | $\begin{aligned} & +15 \mathrm{~V} \pm 5 \% \\ & +15 \mathrm{~V} \pm 10 \% \\ & 5 \mathrm{~mA} \end{aligned}$ |
| TEMPERATURERANGE <br> Rated Performance Operating Storage | $\begin{aligned} & 0 \text { to }+70^{\circ} \mathrm{C} \\ & -40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \\ & -40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \end{aligned}$ | * * | * $\star$ $\star$ |  |
| ```PACKAGE DIMENSIONS \({ }^{4}\) SIP Package( \(\mathbf{Y}\) ) DIP Package (N)``` | $\begin{aligned} & 2.08^{\prime \prime} \times 0.250^{\prime \prime} \times 0.625^{\prime \prime} \times \\ & 2.10^{\prime \prime} \times 0.700^{\prime \prime} \times 0.350^{\prime \prime} \end{aligned}$ | * | * |  |

## NOTES

*Specifications same as AD204J.
${ }^{1}$ Nonlinearity is specified as a \% deviation from a best straight line.
${ }_{2}{ }_{1.0}$ Nonlinearity is specinied decoupling required (see text).
${ }^{2}{ }^{2} 1.0 \mu \mathrm{~F}$ min decoupling requir
"Width is 0.25 " typ, 0.26 " max.
Specifications subject to change without notice.

## PIN DESIGNATIONS

AD202/AD204 SIP PACKAGE

| PIN | FUNCTION |
| :---: | :--- |
| 1 | + INPUT |
| 2 | INPUT/VISO COMMON |
| 3 | -INPUT |
| 4 | INPUT FEEDBACK |
| 5 | -VISOOUTPUT |
| 6 | +VISOOUTPUT |
| 31 |  |
| 32 | + 15V POWERIN (AD202 ONLY) |
| 33 | CLOCK/POWER COMMON |
| 37 | CLOCKINPUT (AD204 ONLY) |
| 38 | OUTPUTLO |
| OUTPUTHI |  |

AD202/AD204 DIPPACKAGE

| PIN | FUNCTION |
| :---: | :--- |
| 1 | +INPUT |
| 2 | INPUT/V ${ }^{\text {ISO }}$ |
| 3 | -INPUMMON |
| 18 | OUTPUT |
| 19 | OUTPUT |
| 20 | + 15V POWERIN (AD202 ONLY) |
| 21 | CLOCK INPUTT(AD204 ONLY) |
| 22 | CLOCK/POWERCOMMON |
| 36 | +VISOOUTPUT |
| 37 | -VISOUTPUT |
| 38 | INPUT FEEDBACK |

ORDERING GUIDE

| Model | Package <br> Option | Max Common- <br> Mode Voltage (Peak) | Max <br> Linearity |
| :--- | :--- | :---: | :--- |
| AD202JY | SIP | 1000 V | $\pm 0.05 \%$ |
| AD202KY | SIP | 2000 V | $\pm 0.025 \%$ |
| AD202JN | DIP | 1000 V | $\pm 0.05 \%$ |
| AD202KN | DIP | 2000 V | $\pm 0.025 \%$ |
| AD204JY | SIP | 1000 V | $\pm 0.05 \%$ |
| AD204KY | SIP | 2000 V | $\pm 0.025 \%$ |
| AD204JN | DIP | 1000 V | $\pm 0.05 \%$ |
| AD204KN | DIP | 2000 V | $\pm 0.025 \%$ |

## OUTLINE DIMENSIONS

Dimensions shown in inches and (mm).


AD202/AD204 DIP PACKAGE


DIFFERENCES BETWEEN THE AD202 AND AD204
The primary distinction between the AD202 and AD204 is in the method by which they are powered: the AD202 operates directly from +15 V dc while the AD204 is powered by a nonisolated externally-supplied clock (AD246) which can drive up to 32 AD204s. The main advantages of using the externally-clocked AD204 over the AD202 are reduced cost in multichannel applications, lower power consumption, and higher bandwidth. In
addition, the AD204 can supply substantially more isolated power than the AD202.
Of course, in a great many situations, especially where only one or a few isolators are used, the convenience of stand-alone operation provided by the AD202 will be more significant than any of the AD204's advantages. There may also be cases where it is desirable to accommodate either device interchangeably, so the pinouts of the two products have been designed to make that easy to do.


Figure 1a. AD202 Functional Block Diagram


Figure 1b. AD204 Functional Block Diagram (Pin Designations Apply to the DIP-Style Package.)

## INSIDE THE AD202 AND AD204

The AD202 and AD204 use an amplitude modulation technique to permit transformer coupling of signals down to dc (Figure la and 1b). Both models also contain an uncommitted input op amp and a power transformer which provides isolated power to the op amp, the modulator, and any external load. The power transformer primary is driven by a $25 \mathrm{kHz}, 15 \mathrm{~V}$ p-p square wave which is generated internally in the case of the AD202, or supplied externally for the AD204.
Within the signal swing limits of approximately $\pm 5 \mathrm{~V}$, the output voltage of the isolator is equal to the output voltage of the op amp; that is, the isolation barrier has unity gain. The output
signal is not internally buffered, so the user is free to interchange the output leads to get signal inversion. Additionally, in multichannel applications, the unbuffered outputs can be multiplexed with one buffer following the mux. This technique minimizes offset errors while reducing power consumption and cost. The output resistance of the isolator is typically $3 \mathrm{k} \Omega$ for the AD204 ( $7 \mathrm{k} \Omega$ for AD202) and varies with signal level and temperature, so it should not be loaded (see Figure 2 for the effects of load upon nonlinearity and gain drift). In many cases a high-impedance load will be present or a following circuit such as an output filter can serve as a buffer, so that a separate buffer function will not often be needed.


Figure 2. Effects of Output Loading
(Circuit figures shown on this page are for SIP style pack-
ages. Refer to page 3 for proper DIP package pin-out.)

## USING THE AD202 AND AD204

Powering the AD202. The AD202 requires only a single +15 V power supply connected as shown in Figure 3a. A bypass capacitor is provided in the module.


Figure 3 a.

Powering the AD204. The AD204 gets its power from an externally supplied clock signal (a 15 V p-p square wave with a nominal frequency of $\mathbf{2 5 k H z}$ ) as shown in Figure 3b.


Figure 3b.
AD246 Clock Driver. The AD246 is a compact, inexpensive clock driver that can be used to obtain the required clock from a single 15 V supply. Alternatively, the circuit shown in Figure 4 (essentially an AD246) can be used. In either case, one clock circuit can operate at least 32 AD204s at the rated minimum supply voltage of 14.25 V and one additional isolator can be operated for each 40 mV increase in supply voltage up to 15 V . A supply bypass capacitor is included in the AD246, but if many AD204s are operated from a single AD246, an external bypass capacitor should be used with a value of at least $1 \mu \mathrm{~F}$ for every five isolators used. Place the capacitor as close as possible to the clock driver.


Figure 4. Clock Driver
(Circuit figures shown on this page are for SIP style packages. Refer to page 3 for proper DIP package pin-out.)

Input Configurations. The AD202 and AD204 have been designed to be very easy to use in a wide range of applications. The basic connection for standard unity gain applications, useful for signals up to $\pm 5 \mathrm{~V}$, is shown in Figure 5; some of the possible variations are described below. When smaller signals must be


Figure 5. Basic Unity-Gain Application
handled, Figure 6 shows how to get gain while preserving a very high input resistance. The value of feedback resistor $\mathbf{R}_{\mathbf{F}}$ should be kept above $20 \mathrm{k} \Omega$ for best results. Whenever a gain of more than five is taken, a 100 pF capacitor from FB to IN COM is required. At lower gains this capacitor is unnecessary, but it will not adversely affect performance if used.


Figure 6. Input Connections for Gain > 1

The "noninverting" circuit of Figures 5 and 6 can also be used to advantage when a signal inversion is needed: just interchange either the input leads or the output leads to get inversion. This approach retains the high input resistance of the "noninverting" circuit, and at unity gain no gain-setting resistors are needed.
When the isolator is not powered, a negative input voltage of more than about 2 V will cause an input current to flow. If the signal source can supply more than a few mA under such conditions, the $2 \mathrm{k} \Omega$ resistor shown in series with $\mathrm{IN}+$ should be used to limit current to a safe value. This is particularly important with the AD202, which may not start if a large input current is present.

Figure 7 shows how to accommodate current inputs or sum currents or voltages. This circuit can also be used when the input signal is larger than the $\pm 5 \mathrm{~V}$ input range of the isolator; for example, a $\pm 50 \mathrm{~V}$ input span can be accommodated with $\mathbf{R}_{\mathbf{F}}=\mathbf{2 0 k}$ and $\mathbf{R}_{\mathbf{S}}=\mathbf{2 0 0 k}$. Once again, a capacitor from FB to IN COM is required for gains above 5.


$$
\begin{aligned}
\mathbf{v}=- & \left(\mathbf{v}_{\mathbf{S} 1} \frac{\mathbf{R}_{\mathbf{F}}}{R_{\mathbf{S} 1}}+\mathbf{v}_{\mathbf{S} 2} \frac{\mathbf{R}_{\mathbf{F}}}{\mathbf{R}_{\mathbf{S} 2}}+\mathbf{I}_{\mathbf{S}} \mathbf{R}_{\mathrm{F}}+\ldots\right) \\
& \mathbf{R}_{\mathrm{F}} \geq \mathbf{2 0 k} \boldsymbol{\Omega}
\end{aligned}
$$

Figure 7. Connections for Summing or Current Inputs

Adjustments. When gain and zero adjustments are needed, the circuit details will depend on whether adjustments are to be made at the isolator input or output, and (for input adjustments) on the input circuit used. Adjustments are usually best done on the input side, because it is better to null the zero ahead of the gain, and because gain adjustment is most easily done as part of the gain-setting network. Input adjustments are also to be preferred when the pots will be near the input end of the isolator (to minimize common-mode strays). Adjustments on the output side might be used if pots on the input side would represent a hazard due to the presence of large common-mode voltages during adjustment.
Figure 8a shows the input-side adjustment connections for use with the "noninverting" connection of the input amplifier. The zero adjustment circuit injects a small adjustment voltage in series with the low side of the signal source. (This will not work if the source has another current path to input common or if current flows in the signal source LO lead). Since the adjustment voltage is injected ahead of the gain, the values shown will work for any gain. Keep the resistance in series with input LO below a few hundred ohms to avoid CMR degradation.
(Circuit figures shown on this page are for SIP style packages. Refer to page 3 for proper DIP package pin-out.)


Figure 8a. Adjustments for Noninverting Connection of Op Amp

Also shown in Figure 8a is the preferred means of adjusting the gain-setting network. The circuit shown gives a nominal $\mathbf{R}_{\mathbf{F}}$ of $50 \mathrm{k} \Omega$, and will work properly for gains of ten or greater. The adjustment becomes less effective at lower gains (its effect is halved at $G=2$ ) so that the pot will have to be a larger fraction of the total $R_{F}$ at low gain. At $G=1$ (follower) the gain cannot be adjusted downward without compromising input resistance; it is better to adjust gain at the signal source or after the output.
Figure 8b shows adjustments for use with inverting input circuits. The zero adjustment nulls the voltage at the summing node. This method is preferable to current injection because it is less affected by subsequent gain adjustment. Gain adjustment is again done in the feedback; but in this case it will work all the way down to unity gain (and below) without alteration.


Figure 8b. Adjustments for Summing or Current Input

Figure 9 shows how zero adjustment is done at the output by taking advantage of the semi-floating output port. The range of this adjustment will have to be increased at higher gains; if that is done, be sure to use a suitably stable supply voltage for the pot circuit.
There is no easy way to adjust gain at the output side of the isolator itself. If gain adjustment must be done on the output side, it will have to be in a following circuit such as an output buffer or filter.


Figure 9. Output-Side Zero Adjustment

Common-Mode Performance. Figures 10a and 10b show how the common-mode rejection of the AD202 and AD204 varies with frequency, gain, and source resistance. For these isolators, the significant resistance will normally be that the path from the source of the common-mode signal to IN COM. The AD202 and AD204 also perform well in applications requiring rejection of fast common-mode steps, as described in the Applications section.


Figure 10a. AD204


Figure 10b. AD202

## APPLICATION EXAMPLE

Process Current Input with Offset. Figure 11 shows an isolator receiver which translates a $4-20 \mathrm{~mA}$ process current signal into a 0 to +10 V output. A 1 V to 5 V signal appears at the isolator's output, and a -1 V reference applied to output LO provides the necessary level shift (in multichannel applications, the reference can be shared by all channels). This technique is often useful for getting offset with a follower-type output buffer.
The circuit as shown requires a source compliance of at least 5 V , but if necessary that can be reduced by using a lower value of current-sampling resistor and configuring the input amplifier for a small gain.

Figure 11. Process Current Input Isolator with Offset


## FEATURES

High CMV Isolation: 2500V RMS Continuous $\pm 3500 V$ Peak Continuous
Small Size: $1 . \mathbf{0 0}^{\prime \prime} \times 2.10^{\prime \prime} \times \mathbf{0 . 3 5 0}{ }^{\prime \prime}$
Three-Port Isolation: Input, Output, and Power
Low Nonlinearity: $\pm \mathbf{0 . 0 1 2 \%}$ max
Wide Bandwidth: 20kHz Full-Power (-3dB)
Low Gain Drift: $\pm 25$ ppm $/{ }^{\circ} \mathrm{C}$ max
High CMR: 120dB ( $G=100 \mathrm{~V} / \mathrm{V}$ )
Isolated Power: $\pm 15 \mathrm{~V} @ \pm 5 \mathrm{~mA}$
Uncommitted Input Amplifier

## APPLICATIONS

Multichannel Data Acquisition High Voltage Instrumentation Amplifier Current Shunt Measurements
Process Signal Isolation

## GENERAL DESCRIPTION

The AD210 is the latest member of a new generation of low cost, high performance isolation amplifiers. This three-port, wide bandwidth isolation amplifier is manufactured with surfacemounted components in an automated assembly process. The AD210 combines design expertise with state-of-the-art manufacturing technology to produce an extremely compact and economical isolator whose performance and abundant user features far exceed those offered in more expensive devices.
The AD210 provides a complete isolation function with both signal and power isolation supplied via transformer coupling internal to the module. The AD210's functionally complete design, powered by a single +15 V supply, eliminates the need for an external DC/DC converter, unlike optically coupled isolation devices. The true three-port design structure permits the AD210 to be applied as an input or output isolator, in single or multichannel applications. The AD210 will maintain its high performance under sustained common-mode stress.

Providing high accuracy and complete galvanic isolation, the AD210 interrupts ground loops and leakage paths, and rejects common-mode voltage and noise that may otherwise degrade measurement accuracy. In addition, the AD210 provides protection from fault conditions that may cause damage to other sections of a measurement system.

## PRODUCT HIGHLIGHTS

The AD210 is a full-featured isolator providing numerous user benefits including:

High Common-Mode Performance: The AD210 provides 2500V rms (Continuous) and $\pm 3500 \mathrm{~V}$ peak (Continuous) common-mode voltage isolation between any two ports. Low input to output

## FUNCTIONAL BLOCK DIAGRAM


capacitance of 5 pF results in a 120 dB CMR at a gain of 100 , and a low leakage current ( $2 \mu \mathrm{~A}$ rms max @ 240 V rms, 60 Hz ).
High Accuracy: With maximum nonlinearity of $\pm 0.012 \%$ (B Grade), gain drift of $\pm 25 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ max, and input offset drift of ( $\pm 10 \pm 30 / \mathrm{G}) \mu \mathrm{V} /{ }^{\circ} \mathrm{C}$, the AD210 assures signal integrity while providing high level isolation.
Wide Bandwidth: The AD210's full-power bandwidth of 20 kHz makes it useful for wideband signals. It is also effective in applications like control loops, where limited bandwidth could result in instability.
Small Size: The AD210 provides a complete isolation function in a small DIP package just $1.00^{\prime \prime} \times 2.10^{\prime \prime} \times 0.350^{\prime \prime}$. The low profile DIP package allows application in $0.5^{\prime \prime}$ card racks and assemblies. The pinout is optimized to facilitate board layout while maintaining isolation spacing between ports.
Three-Port Design: The AD210's three-port design structure allows each port (Input, Output, and Power) to remain independent. This three-port design permits the AD210 to be used as an input or output isolator. It also provides additional system protection should a fault occur in the power source.
Isolated Power: $\pm 15 \mathrm{~V} @ 5 \mathrm{~mA}$ is available at the input and output sections of the isolator. This feature permits the AD210 to excite floating signal conditioners, front-end amplifiers and remote transducers at the input as well as other circuitry at the output.
Flexible Input: An uncommitted operational amplifier is provided at the input. This amplifier provides buffering and gain as required, and facilitates many alternative input functions as required by the user.

[^212][^213]

AD210 Pin Designations

| PIN | DESIGNATION | FUNCTION |
| :---: | :--- | :--- |
| 1 | $\mathrm{~V}_{\mathrm{O}}$ | Output |
| 2 | $\mathrm{O}_{\text {cOM }}$ | Output Common |
| 3 | $+\mathrm{V}_{\text {OSS }}$ | + Isolated Power @ Output |
| 4 | $-\mathrm{V}_{\text {OSS }}$ | - Isolated Power @ Output |
| 14 | $+\mathrm{V}_{\text {ISS }}$ | + Isolated Power @ Input |
| 15 | $-\mathrm{V}_{\text {ISS }}$ | - Isolated Power @ Input |
| 16 | FB | Input Feedback |
| 17 | - IN | - Input |
| 18 | I Com | Input Common |
| 19 | $+\mathbb{I N}$ | + Input |
| 29 | Pwr Com | Power Common |
| 30 | Pwr | Power Input |

## NOTES

*Specifications same as AD210AN.
${ }^{1}$ Nonlinearity is specified as a \% deviation from a best straight line.
${ }^{2}$ RTI - Referred to Input
${ }^{3}$ A reduced signal swing is recommended when both $\pm \mathrm{V}_{\text {ISS }}$ and $\pm \mathrm{V}_{\text {oss }}$ supplies are fully loaded, due to supply voltage reduction.
${ }^{4}$ See text for detailed information.
Specifications subject to change without notice.

AC1059 Mating Socket


## OUTLINE DIMENSIONS

Dimensions shown in inches and (mm).


## AD210

## INSIDE THE AD210

The AD210 basic block diagram is illustrated in Figure 1. A +15 V supply is connected to the power port, and $\pm 15 \mathrm{~V}$ isolated power is supplied to both the input and output ports via a 50 kHz carrier frequency. The uncommitted input amplifier can be used to supply gain or buffering of input signals to the AD210. The fullwave modulator translates the signal to the carrier frequency for application to transformer T1. The synchronous demodulator in the output port reconstructs the input signal. A 20 kHz , threepole filter is employed to minimize output noise and ripple. Finally, an output buffer provides a low impedance output capable of driving a $2 \mathrm{k} \Omega$ load.


Figure 1. AD210 Block Diagram

## USING THE AD210

The AD210 is very simple to apply in a wide range of applications. Powered by a single +15 V power supply, the AD210 will provide outstanding performance when used as an input or output isolator, in single and multichannel configurations.

Input Configurations: The basic unity gain configuration for signals up to $\pm 10 \mathrm{~V}$ is shown in Figure 2. Additional input amplifier variations are shown in the following figures. For smaller signal levels Figure 3 shows how to obtain gain while maintaining a very high input impedance.


Figure 2. Basic Unity Gain Configuration

The high input impedance of the circuits in Figures 2 and 3 can be maintained in an inverting application. Since the AD210 is a three-port isolator, either the input leads or the output leads may be interchanged to create the signal inversion.


Figure 3. Input Configuration for $\mathbf{G}>1$
Figure 4 shows how to accommodate current inputs or sum currents or voltages. This circuit configuration can also be used for signals greater than $\pm 10 \mathrm{~V}$. For example, a $\pm 100 \mathrm{~V}$ input span can be handled with $R_{F}=20 \mathrm{k} \Omega$ and $\mathrm{R}_{\mathrm{S} 1}=200 \mathrm{k} \Omega$.


$$
\mathrm{V}_{\mathrm{ouT}}=-\mathbf{R}_{\mathrm{F}}\left(\frac{V_{\mathrm{S}}}{R_{\mathrm{S} 1}}+\frac{\mathrm{V}_{\mathrm{S} 2}}{R_{\mathrm{S} 2}}+\mathrm{I}_{\mathrm{s}}+\ldots\right)
$$

Figure 4. Summing or Current Input Configuration

## Adjustments

When gain and offset adjustments are required, the actual circuit adjustment components will depend on the choice of input configuration and whether the adjustments are to be made at the isolator's input or output. Adjustments on the output side might be used when potentiometers on the input side would represent a hazard due to the presence of high common-mode voltage during adjustment. Offset adjustments are best done at the input side, as it is better to null the offset ahead of the gain.
Figure 5 shows the input adjustment circuit for use when the input amplifier is configured in the noninverting mode. This offset adjustment circuit injects a small voltage in series with the


Figure 5. Adjustments for Noninverting Input
low side of the signal source. This will not work if the source has another current path to input common or if current flows in the signal source LO lead. To minimize CMR degradation, keep the resistor in series with the input LO below a few hundred ohms.

Figure 5 also shows the preferred gain adjustment circuit. The circuit shows $R_{F}$ of $50 \mathrm{k} \Omega$, and will work for gains of ten or greater. The adjustment becomes less effective at lower gains (its effect is halved at $G=2$ ) so that the pot will have to be a larger fraction of the total $R_{F}$ at low gain. At $G=1$ (follower) the gain cannot be adjusted downward without compromising input impedance; it is better to adjust gain at the signal source or after the output.
Figure 6 shows the input adjustment circuit for use when the input amplifier is configured in the inverting mode. The offset adjustment nulls the voltage at the summing node. This is preferable to current injection because it is less affected by subsequent gain adjustment. Gain adjustment is made in the feedback and will work for gains from 1 to $100 \mathrm{~V} / \mathrm{V}$.


Figure 6. Adjustments for Inverting Input
Figure 7 shows how offset adjustments can be made at the output, by offsetting the floating output port. In this circuit, $\pm 15 \mathrm{~V}$ would be supplied by a separate source. The AD210's output amplifier is fixed at unity, therefore, output gain must be made in a subsequent stage.


Figure 7. Output-Side Offset Adjustment

## PERFORMANCE CHARACTERISTICS

Common-Mode Rejection: Figure 9 shows the common-mode rejection of the AD210 versus frequency, gain and input source resistance. For maximum common-mode rejection of unwanted signals, keep the input source resistance low and carefully lay out the input, avoiding excessive stray capacitance at the input terminals.


Figure 9. Common-Mode Rejection vs. Frequency

Phase Shift: Figure 10 illustrates the AD210's low phase shift and gain versus frequency. The AD210's phase shift and wide bandwidth performance make it well suited for applications like power monitors and controls systems.


Figure 10. Phase Shift and Gain vs. Frequency

Isolated Power: The AD210 provides isolated power at the input and output ports. This power is useful for various signal conditioning tasks. Both ports are rated at a nominal $\pm 15 \mathrm{~V}$ at 5 mA .

The load characteristics of the isolated power supplies are shown in Figure 15. For example, when measuring the load rejection of the input isolated supplies $\mathrm{V}_{\text {ISS }}$, the load is placed between $+V_{\text {Iss }}$ and $-V_{\text {Iss. }}$. The curves labeled $V_{\text {Iss }}$ and $V_{\text {oss }}$ are the individual load rejection characteristics of the input and the output supplies, respectively.
There is also some effect on either isolated supply when loading the other supply. The curve labeled CROSSLOAD indicates the sensitivity of either the input or output supplies as a function of the load on the opposite supply.


Figure 15. Isolated Power Supplies vs. Load
Lastly, the curves labeled $V_{\text {Oss }}$ simultaneous and $V_{\text {Iss }}$ simultaneous indicate the load characteristics of the isolated power supplies when an equal load is placed on both supplies.
The AD210 provides short circuit protection for its isolated power supplies. When either the input supplies or the output supplies are shorted to input common or output common, respectively, no damage will be incurred, even under continuous application of the short. However, the AD210 may be damaged if the input and output supplies are shorted simultaneously.


Figure 16a. Isolated Supply Ripple vs. Load (External 4.7 7 F Bypass)

Under any circumstances, care should be taken to ensure that the power supplies do not accidentally become shorted.
The isolated power supplies exhibit some ripple which varies as a function of load. Figure 16a shows this relationship. The AD210 has internal bypass capacitance to reduce the ripple to a point where performance is not affected, even under full load. Since the internal circuitry is more sensitive to noise on the negative supplies, these supplies have been filtered more heavily. Should a specific application require more bypassing on the isolated power supplies, there is no problem with adding external capacitors. Figure 16b depicts supply ripple as a function of external bypass capacitance under full load.


Figure 16b. Isolated Power Supply Ripple vs. Bypass Capacitance (Volts p-p, 1MHz Bandwidth, 5mA Load)

## Isolated V-to-I Converter

Illustrated in Figure 19, the AD210 is used to convert a 0 to +10 V input signal to an isolated $4-20 \mathrm{~mA}$ output current. The AD210 isolates the 0 to +10 V input signal and provides a proportional voltage at the isolator's output. The output circuit converts the input voltage to a $\mathbf{4 - 2 0 \mathrm { mA }}$ output current, which in turn is applied to the loop load $\mathbf{R}_{\text {LoAd }}$.


Figure 19. Isolated Voltage-to-Current Loop Converter


Figure 22. Multichannel Data Acquisition Front End

## MULTICHANNEL DATA ACQUISITION FRONT-END

Illustrated in Figure 22 is a four-channel data acquisition front-end used to condition and isolate several common input signals found in various process applications. In this application, each AD210 will provide complete isolation from input to output as well as channel to channel. By using an isolator per channel, maximum protection and rejection of unwanted signals is obtained. The three-port design allows the AD210 to be configured as an input or output isolator. In this application the isolators are configured as input devices with the power port providing additional protection from possible power source faults.
Channel 1: The AD210 is used to convert a $4-20 \mathrm{~mA}$ current loop input signal into a $0-10 \mathrm{~V}$ input. The $25 \Omega$ shunt resistor converts the $4-20 \mathrm{~mA}$ current into a +100 to +500 mV signal. The signal is offset by -100 mV via $\mathrm{R}_{\mathrm{O}}$ to produce a 0 to +400 mV input. This signal is amplified by a gain of 25 to produce the desired 0 to +10 V output. With an open circuit, the AD210 will show -2.5 V at the output.
Channel 2: In this channel, the AD210 is used to condition and isolate a current output temperature transducer, Model AD590. At $+25^{\circ} \mathrm{C}$, the AD590 produces a nominal current of $298.2 \mu \mathrm{~A}$. This level of current will change at a rate of $1 \mu \mathrm{~A} /{ }^{\circ} \mathrm{C}$. At $-17.8^{\circ} \mathrm{C}$ ( $0^{\circ} \mathrm{F}$ ), The AD590 current will be reduced by $42.8 \mu \mathrm{~A}$ to $+255.4 \mu \mathrm{~A}$. The AD580 reference circuit provides an equal but
opposite current, resulting in a zero net current flow, producing a 0 V output from the AD 210 . $\mathrm{At}+100^{\circ} \mathrm{C}\left(+212^{\circ} \mathrm{F}\right)$, the AD590 current output will be $373.2 \mu \mathrm{~A}$ minus the $255.4 \mu \mathrm{~A}$ offsetting current from the AD580 circuit to yield a $+117.8 \mu \mathrm{~A}$ input current. This current is converted to a voltage via $R_{F}$ and $R_{G}$ to produce an output of +2.12 V . Channel 2 will produce an output of $+10 \mathrm{mV} / /^{\circ} \mathrm{F}$ over a 0 to $+212^{\circ} \mathrm{F}$ span.
Channel 3: Channel 3 is a low level input channel configured with a high gain amplifier used to condition millivolt signals. With the AD210's input set to unity and the input amplifier set for a gain of $1000, \mathrm{a} \pm 10 \mathrm{mV}$ input will produce a $\pm 10 \mathrm{~V}$ at the AD210's output.

Channel 4: Channel 4 illustrates one possible configuration for conditioning a bridge circuit. The AD584 produces a +10 V excitation voltage, while A1 inverts the voltage, producing negative excitation. A2 provides a gain of $1000 \mathrm{~V} / \mathrm{V}$ to amplify the low level bridge signal. Additional gain can be obtained by reconfiguration of the AD210's input amplifier. $\pm \mathrm{V}_{\text {ISs }}$ provides the complete power for this circuit, eliminating the need for a separate isolated excitation source.

Each channel is individually addressed by the multiplexer's channel select. Additional filtering or signal conditioning should follow the multiplexer, prior to an analog-to-digital conversion stage.

## Comparators Contents

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CMP04 - Quad Low Power, Precision Comparator ..... 12-16

Selection Tree－Comparators


## Selection Guide-Comparators

| Model | Prop <br> Delay <br> ns <br> max | Dispersion ps | Logic | $V_{\text {os }}$ mV <br> max | Package Options ${ }^{1}$ | Temp Ranges ${ }^{2}$ | Comments | Page ${ }^{3}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| AD1317 | 2.5 | 250 | ECL | 10 | Z | I, M/D | Dedicated Window Comparator with Wide CM Range | SL 6-15 |
| AD96685 | 3.5 | 50 | ECL | 2 | $\mathbf{E}, \mathbf{H}, \mathbf{P}, \mathbf{Q}, \mathbf{R}$ | I, M/ ${ }_{\text {D }}$ | Ultrafast | 12-13 |
| AD96687 | 3.5 | 50 | ECL | 2 | $\mathbf{E}, \mathbf{P}, \mathbf{Q}, \mathbf{R}$ | I, M/ | Dual AD96685 | 12-13 |
| AD9696 | 7.0 | 100 | TTL | 2 | $\mathbf{H}, \mathbf{N}, \mathbf{Q}, \mathbf{R}, \mathbf{Z}$ | C, M/ | Single Comparator | 12-9 |
| AD9698 | 7.0 | 100 | TTL | 2 | $\mathbf{H}, \mathbf{Q}, \mathbf{R}, \mathbf{Z}$ | C, M/ | Dual Comparator | 12-9 |
| AD790 | 45 | - | TTL | 0.25-1 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, $\mathrm{I}, \mathrm{M} / \mathrm{D}$ | Fast, Precise Single or Dual Supply | 12-5 |
| CMP05 | 55 | - | TTL | 0.6 | H, N, Q, R | I, M/ | High Speed Precision Comparator | A 3-51 |
| CMP01 | 180 | - | TTL | 0.8 | H, N, Q | C, $\mathrm{M} / \mathrm{D}$ | Fast Precision Comparator | A 3-27 |
| CMP02 | 270 | - | TTL | 0.8 | H, N, Q | C, M | Low Input Current Precision Comparator | A 3-35 |
| CMP04 | 300 typ | - | TTL | 1.0 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M/ ${ }_{\text {D }}$ | Quad Low Power Precision Comparator | 12-16 |
| PM139 | 1300 | - | TTL | 2 | D, E, N | I, M/ ${ }_{\text {DJ }}$ | Low Power, Single or Dual Supply | A 3-65 |
| PM239 | 1300 | - | TTL | 2 | D, E, N | I, M | Low Power, Single or Dual Supply | A 3-65 |

${ }^{1}$ Package Options: D = Hermetic DIP, Ceramic or Metal; E = Ceramic Leadless Chip Carrier; F = Ceramic Flatpack; G $=$ Ceramic Pin Grid Array; H $=$ Hermetic Metal Can; J $=\mathrm{J}$-Leaded Ceramic Package; M = Hermetic Metal Can DIP; N = Plastic or Epoxy Sealed DIP; P = Plastic Leaded Chip Carrier; Q = Cerdip; R = Small Outline "SOIC" Package; RS = SSOP -Shrink Small Outline Package; S = Plastic Quad Flatpack; ST = Thin Quad Flatpack; $T=$ TO-92; U = TSOP-Thin Small Outline Package; $\mathrm{W}=$ Nonhermetic Ceramic/Glass DIP; $\mathrm{Y}=$ Single-In-Line "SIP" Package; $\mathrm{Z}=$ Ceramic Leaded Chip Carrier. ${ }^{2}$ Temperature Ranges: $\mathrm{C}=$ Commercial, $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C} ; \mathrm{I}=$ Industrial, $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ (Some older products $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ); $\mathrm{M}=$ Military, $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. If a device has military grade offerings, the M temperature designator will be followed by: / to indicate 883B, ${ }_{J}$ for JAN, ${ }_{D}$ for SMD, and ${ }_{\mathrm{s}}$ for space level.
${ }^{3} \mathrm{~A}=$ Amplifier Reference Manual; $\mathrm{SL}=$ Special Linear Reference Manual. All other entries refer to this volume.
Boldface Type: Data sheet information in this volume.

## FEATURES

45 ns max Propagation Delay
Single +5 V or Dual $\pm 15$ V Supply Operation
CMOS or TTL Compatible Output
$250 \mu \mathrm{~V}$ max Input Offset Voltage
$500 \mu \mathrm{~V}$ max Input Hysteresis Voltage
15 V max Differential Input Voltage
On-Board Latch
60 mW Power Dissipation
Available in 8-Pin Plastic and Hermetic Cerdip Packages
MIL-STD-883B Processing Available
Available in Tape and Reel in Accordance with EIA-481A Standard

## APPLICATIONS

Zero-Crossing Detectors
Overvoltage Detectors
Pulse-Width Modulators
Precision Rectifiers
Discrete A/D Converters
Delta-Sigma Modulator A/Ds

## PRODUCT DESCRIPTION

The AD790 is a fast ( 45 ns ), precise voltage comparator, with a number of features that make it exceptionally versatile and easy to use. The AD790 may operate from either a single +5 V supply or a dual $\pm 15 \mathrm{~V}$ supply. In the single-supply mode, the AD790's inputs may be referred to ground, a feature not found in other comparators. In the dual-supply mode it has the unique ability of handling a maximum differential voltage of 15 V across its input terminals, easing their interfacing to large amplitude and dynamic signals.

This device is fabricated using Analog Devices' Complementary Bipolar (CB) process - which gives the AD790's combination of fast response time and outstanding input voltage resolution ( 1 mV max). To preserve its speed and accuracy, the AD790 incorporates a "low glitch" output stage that does not exhibit the large current spikes normally found in TTL or CMOS output stages. Its controlled switching reduces power supply disturbances that can feed back to the input and cause undesired oscillations. The AD790 also has a latching function which makes it suitable for applications requiring synchronous operation.

The AD790 is available in five performance grades. The AD790J and the AD790K are rated over the commercial temperature range of 0 to $+70^{\circ} \mathrm{C}$. The AD790A and AD790B are rated over the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. The AD790S is rated over the military temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ and is available processed to MIL-STD-883B, Rev. C.

## PRODUCT HIGHLIGHTS

1. The AD790's combination of speed, precision, versatility and low cost makes it suitable as a general purpose comparator in analog signal processing and data acquisition systems.
2. Built-in hysteresis and a low-glitch output stage minimize the chance of unwanted oscillations, making the AD790 easier to use than standard open-loop comparators.
3. The hysteresis combined with a wide input voltage range enables the AD790 to respond to both slow, low level (e.g., 10 mV ) signals and fast, large amplitude (e.g., 10 V ) signals.
4. A wide variety of supply voltages are acceptable for operation of the AD790, ranging from single +5 V to dual $+5 \mathrm{~V} /-12 \mathrm{~V}$, $\pm 5 \mathrm{~V}$, or $+5 \mathrm{~V} / \pm 15 \mathrm{~V}$ supplies.
5. The AD790's power dissipation is the lowest of any comparator in its speed range.
6. The AD790's output swing is symmetric between $V_{\text {LOGIC }}$ and ground, thus providing a predictable output under a wide range of input and output conditions.

## AD790-SPECIFICATIONS

DUAL SUPPLY (Operation @ $+25^{\circ} \mathrm{C}$ and $+\mathrm{V}_{\mathrm{s}}=+15 \mathrm{~V},-\mathrm{V}_{\mathrm{s}}=-15 \mathrm{~V}, \mathrm{v}_{\text {togic }}=+5 \mathrm{~V}$ unless otherwise noted)


## NOTES

${ }^{1}$ Defined as the average of the input voltages at the low to high and high to low transition points. Refer to Figure 14.
${ }^{2}$ Defined as half the magnitude between the input voltages at the low to high and high to low transition points. Refer to Figure 14.
${ }^{3}+\mathrm{V}_{\mathrm{s}}$ must be no lower than ( $\mathrm{V}_{\text {LoGIC }}-0.5 \mathrm{~V}$ ) in any supply operating conditions, except during power up.
All min and max specifications are guaranteed. Specifications shown in boldface are tested on all production units at final test.
Specifications subject to change without notice.

SINGLE SUPPLY (Operation @ $+25^{\circ} \mathrm{C}$ and $+V_{S}=V_{\text {Logic }}=+5 \mathrm{~V},-\mathbf{V}_{\mathrm{S}}=0$ unless otherwise noted) ${ }^{1}$


## NOTES

${ }^{1}$ Pin 1 tied to Pin 8, and Pin 4 tied to Pin 6.
${ }^{2}$ Defined as the average of the input voltages at the low to high and high to low transition points. Refer to Figure 14.
${ }^{3}$ Defined as half the magnitude between the input voltages at the low to high and high to low transition points. Refer to Figure 14.
${ }^{4}-V_{S}$ must not be connected above ground.
Specifications subject to change without notice.
All min and max specifications are guaranteed. Specifications shown in boldface are tested on all production units at final test.

## AD790

ABSOLUTE MAXIMUM RATINGS ${ }^{1,2}$
Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 18$ V Internal Power Dissipation ${ }^{2}$. . . . . . . . . . . . . . . . . . 500 mW
Differential Input Voltage . . . . . . . . . . . . . . . . . . . $\pm 16.5 \mathrm{~V}$
Output Short Circuit Duration . . . . . . . . . . . . . . . Indefinite
Storage Temperature Range
(N, R) . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
(Q) . . . . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

Lead Temperature Range (Soldering 60 sec ) . . . . . . $+300^{\circ} \mathrm{C}$
Logic Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . . 7 V

## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functionaloperation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ Thermal characteristics: plastic $\mathrm{N}-8$ package: $\theta_{\mathrm{JA}}=90^{\circ} \mathrm{C} /$ watt; ceramic $\mathrm{Q}-8$ package: $\theta_{\mathrm{JA}}=110^{\circ} \mathrm{C} /$ watt, $\theta_{\mathrm{JC}}=30^{\circ} \mathrm{C} /$ watt.
SOIC (R-8) package: $\theta_{\mathrm{JA}}=160^{\circ} \mathrm{C} /$ watt; $\theta_{\mathrm{JC}}=42^{\circ} \mathrm{C} /$ watt.

ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD790JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Plastic DIP | $\mathrm{N}-8$ |
| AD790JR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | SOIC | $\mathrm{R}-8$ |
| AD790JR-REEL | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Reel |  |
| AD790KN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Plastic DIP | $\mathrm{N}-8$ |
| AD790AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Cerdip | $\mathrm{Q}-8$ |
| AD790BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Cerdip | $\mathrm{Q}-8$ |
| AD790SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Cerdip | $\mathrm{Q}-8$ |
| AD790SQ/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Cerdip | $\mathrm{Q}-8$ |
| AD790S Chips | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Die |  |

*For outline information see Package Information section.


Figure 2. Basic Single Supply Configuration (N, Q Package Pinout)

Figure 1. Basic Dual Supply Configuration (N, Q Package Pinout)

FEATURES

4.5 ns Propagation Delay<br>200 ps Maximum Propagation Delay Dispersion<br>Single +5 V or $\pm 5$ V Supply Operation<br>Complementary Matched TTL Outputs

## APPLICATIONS

High Speed Line Receivers
Peak Detectors
Window Comparators
High Speed Triggers
Ultrafast Pulse Width Discriminators

## GENERAL DESCRIPTION

The AD9696 and AD9698 are ultrafast TTL-compatible voltage comparators able to achieve propagation delays previously possible only in high performance ECL devices. The AD9696 is a single comparator providing 4.5 ns propagation delay, 200 ps maximum delay dispersion and 1.7 ns setup time. The AD9698 is a dual comparator with equally high performance; both devices are ideal for critical timing circuits in such applications as ATE, communications receivers and test instruments.

Both devices allow the use of either a single +5 V supply or $\pm 5 \mathrm{~V}$ supplies. The choice of supplies determines the common mode input voltage range available: -2.2 V to +3.7 V for $\pm 5 \mathrm{~V}$ operation, +1.4 V to +3.7 V for single +5 V supply operation.
The differential input stage features high precision, with offset voltages which are less than 2 mV and offset currents less than $1 \mu \mathrm{~A}$. A latch enable input is provided to allow operation in either sample-and-hold or track-and-hold applications.

The AD9696 and AD9698 are both available as commercial temperature range devices operating from ambient temperatures of $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$, and as extended temperature range devices for ambient temperatures from $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. Both versions are available qualified to MIL-STD-883 class B.

Package options for the AD9696 include a 10-pin TO-100 metal can, an 8 -pin ceramic DIP, an 8 -pin plastic DIP, and an 8 -lead small outline plastic package. The AD9698 is available in a 16 -pin ceramic DIP, a 16 -lead ceramic gullwing, a 16 -pin plastic DIP, and a 16-lead small outline plastic package. Military qualified versions of the AD9696 come in the TO-100 can and ceramic DIP; the dual AD9698 comes in ceramic IIIP.

## FUNCTIONAL BLOCK DIAGRAM



## AD9696/AD9698-SPECIFICATIONS

ABSOLUTE MAXIMUM RATINGS ${ }^{1}$
Supply Voltage ( $+\mathrm{V}_{\mathrm{S}} /-\mathrm{V}_{\mathrm{S}}$ ) . . . . . . . . . . . . . . . $+7 \mathrm{~V} /-7 \mathrm{~V}$
Input Voltage Range . . . . . . . . . . . . . . . . . . . . . . . . $\pm 5 \mathrm{~V}$
Differential Input Voltage . . . . . . . . . . . . . . . . . . . . . 5.4 V
Latch Enable Voltage . . . . . . . . . . . . . . . . . -0.5 V to $+\mathrm{V}_{\mathrm{s}}$
Output Current (Continuous) . . . . . . . . . . . . . . . . . . 20 mA
Power Dissipation . . . . . . . . . . . . . . . . . . . . . . . . 600 mW

Operating Temperature Range ${ }^{2}$
AD9696/AD9698KH/KN/KQ/KR ${ }^{3} \ldots . . .0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
AD9696/AD9698TH/TQ ${ }^{3}$. . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Junction Temperature
KH/KQ/TH/TQ Suffixes . . . . . . . . . . . . . . . . . . $+175^{\circ} \mathrm{C}$
KN/KR Suffixes . . . . . . . . . . . . . . . . . . . . . . . . $+150^{\circ} \mathrm{C}$
Lead Soldering Temperature ( 10 sec ) . . . . . . . . . . . . $+300^{\circ} \mathrm{C}$


| Parameter | Temp | Test Level | $\begin{gathered} 0^{\circ} \mathrm{C} \text { to }+70^{\circ} \mathrm{C} \\ \text { AD9696/AD9698 } \end{gathered}$ <br> KH/KN/KQ/KR ${ }^{3}$ |  |  | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ AD9696/AD9698 TH/TQ ${ }^{3}$ |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max | Min | Typ | Max |  |
| INPUT CHARACTERISTICS |  |  |  |  |  |  |  |  |  |
| Input Offset Voltage ${ }^{5}$ | $+25^{\circ} \mathrm{C}$ | I |  | 1.0 | 2.0 |  | 1.0 | 2.0 | mV |
|  | Full | VI |  |  | 3.0 |  |  | 3.0 | mV |
| Input Offset Voltage Drift | Full | V |  | 10 |  |  | 10 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Bias Current | $+25^{\circ} \mathrm{C}$ | I |  | 16 | 55 |  | 16 | 55 | $\mu \mathrm{A}$ |
|  | Full | VI |  |  | 110 |  |  | 110 | $\mu \mathrm{A}$ |
| Input Offset Current | $+25^{\circ} \mathrm{C}$ | I |  | 0.4 | 1.0 |  | 0.4 | 1.0 | $\mu \mathrm{A}$ |
|  | Full | VI |  |  | 1.3 |  |  | 1.3 | $\mu \mathrm{A}$ |
| Input Capacitance | $+25^{\circ} \mathrm{C}$ | V |  | 3 |  |  | 3 |  | pF |
| Input Voltage Range |  |  |  |  |  |  |  |  |  |
| $\pm 5.0 \mathrm{~V}$ | Full | VI | -2.2 |  | +3.7 | -2.2 |  | +3.7 | V |
| $+5.0 \mathrm{~V}$ | Full | VI | +1.4 |  | +3.7 | +1.4 |  | +3.7 | V |
| Common Mode Rejection Ratio |  |  |  |  |  |  |  |  |  |
| , +5.0 V | Full | VI | 57 | 63 |  | 57 | 63 |  | dB |
| LATCH ENABLE INPUT |  |  |  |  |  |  |  |  |  |
| Logic " 1 " Voltage Threshold | Full | VI | 2.0 |  |  | 2.0 |  |  | V |
| Logic "0" Voltage Threshold | Full | VI |  |  | 0.8 |  |  | 0.8 | V |
| Logic " 1 " Current | Full | VI |  |  | 10 |  |  | 10 | $\mu \mathrm{A}$ |
| Logic "0" Current | Full | VI |  |  | 1 |  |  | 1 | $\mu \mathrm{A}$ |
| DIGITAL OUTPUTS |  |  |  |  |  |  |  |  |  |
| Logic " 1 " Voltage (Source 4 mA ) | Full | VI | 2.7 | 3.5 |  | 2.7 | 3.5 |  | V |
| Logic " 0 " Voltage (Sink 10 mA ) | Full | VI |  | 0.4 | 0.5 |  | 0.4 | 0.5 | V |
| SWITCHING PERFORMANCE |  |  |  |  |  |  |  |  |  |
| Propagation Delay ( $\left.\mathrm{t}_{\mathrm{PD}}\right)^{6}$ |  |  |  |  |  |  |  |  |  |
| Input to Output HIGH | Full | IV |  | 4.5 | 7.0 |  | 4.5 | 7.0 | ns |
| Input to Output LOW | Full | IV |  | 4.5 | 7.0 |  | 4.5 | 7.0 | ns |
| Latch Enable to Output HIGH | $+25^{\circ} \mathrm{C}$ | IV |  | 6.5 | 8.5 |  | 6.5 | 8.5 | ns |
| Latch Enable to Output LOW | $+25^{\circ} \mathrm{C}$ | IV |  | 6.5 | 8.5 |  | 6.5 | 8.5 | ns |
| Delta Delay Between Outputs | $+25^{\circ} \mathrm{C}$ | IV |  | 0.5 | 1.5 |  | 0.5 | 1.5 | ns |
| Propagation Delay Dispersion |  |  |  |  |  |  |  |  |  |
| 20 mV to 100 mV Overdrive | $+25^{\circ} \mathrm{C}$ | V |  | 100 |  |  | 100 |  | ps |
| 100 mV to 1.0 V Overdrive | $+25^{\circ} \mathrm{C}$ | IV |  | 100 | 200 |  | 100 | 200 | ps |
| Rise Time ${ }^{11}$ | $+25^{\circ} \mathrm{C}$ | V |  | 1.85 |  |  | 1.85 |  | ns |
| Fall Time ${ }^{11}$ | $+25^{\circ} \mathrm{C}$ | V |  | 1.35 |  |  | 1.35 |  | ns |
| Latch Enable |  |  |  |  |  |  |  |  |  |
| Pulse Width [ $\mathrm{t}_{\mathrm{PWW}(\mathrm{E})}$ ] | $+25^{\circ} \mathrm{C}$ | IV | 3.5 | 2.5 |  | 3.5 | 2.5 |  | ns |
| Setup Time ( $\mathrm{t}_{\text {s }}$ ) | $+25^{\circ} \mathrm{C}$ | IV | 3 | 1.7 |  | 3 | 1.7 |  | ns |
| Hold Time ( $\mathrm{t}_{\mathrm{H}}$ ) | $+25^{\circ} \mathrm{C}$ | IV | 3 | 1.9 |  | 3 | 1.9 |  | ns |


| Parameter | Temp | Test Level | $\begin{gathered} 0^{\circ} \mathrm{C} \text { to }+70^{\circ} \mathrm{C} \\ \text { AD9696/AD9698 } \\ \text { KH/KN/KQ/KR }{ }^{3} \end{gathered}$ |  |  | $\begin{gathered} -55^{\circ} \mathrm{C} \text { to }+125^{\circ} \mathrm{C} \\ \text { AD9696/AD9698 } \\ \text { TH/TQ }{ }^{3} \end{gathered}$ |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max | Min | Typ | Max |  |
| POWER SUPPLY ${ }^{7}$ |  |  |  |  |  |  |  |  |  |
| Positive Supply Current ${ }^{8}$ |  |  |  |  |  |  |  |  | $(+5.0 \mathrm{~V})$ |
| AD9696 | Full | VI |  | 26 | 32 |  | 26 | 32 | mA |
| AD9698 | Full | VI |  | 52 | 64 |  | 52 | 64 | mA |
| Negative Supply Current ${ }^{9}$ |  |  |  |  |  |  |  |  | (-5.2 V) |
| AD9696 | Full | VI |  | 2.5 | 4.0 |  | 2.5 | 4.0 | mA |
| AD9698 | Full | VI |  | 5.0 | 8.0 |  | 5.0 | 8.0 | mA |
| Power Dissipation |  |  |  |  |  |  |  |  |  |
| AD9696 +5.0 V | Full | V |  | 130 |  |  | 130 |  | mW |
| AD9696 $\pm 5.0 \mathrm{~V}$ | Full | V |  | 146 |  |  | 146 |  | mW |
| AD9698 +5.0 V | Full | V |  | 260 |  |  | 260 |  | mW |
| AD9698 $\pm 5.0 \mathrm{~V}$ | Full | V |  | 292 |  |  | 292 |  | mW |
| Power Supply Rejection Ratio ${ }^{10}$ | $+25^{\circ} \mathrm{C}$ | VI | 70 |  |  | 70 |  |  | dB |
|  | Full | VI | 65 |  |  | 65 |  |  | dB |

## NOTES

${ }^{1}$ Absolute maximum ratings are limiting values, to be applied individually, and beyond which the serviceability of the circuit may be impaired. Functional operability is not necessarily implied. Exposure to absolute maximum rating conditions for an extended period of time may affect device reliability.
${ }^{2}$ Typical thermal impedances:

| AD9696 Metal Can | $\theta_{\mathrm{JA}}=170^{\circ} \mathrm{C} / \mathrm{W}$ | $\theta_{\mathrm{JC}}=50^{\circ} \mathrm{C} / \mathrm{W}$ |
| :--- | :--- | :--- |
| AD9696 Ceramic DIP | $\theta_{\mathrm{JA}}=110^{\circ} \mathrm{C} / \mathrm{W}$ | $\theta_{\mathrm{JC}}=20^{\circ} \mathrm{C} / \mathrm{W}$ |
| AD9696 Plastic DIP | $\theta_{\mathrm{JA}}=160^{\circ} \mathrm{C} / \mathrm{W}$ | $\theta_{\mathrm{JC}}=30^{\circ} \mathrm{C} / \mathrm{W}$ |
| AD9696 Plastic SOIC | $\theta_{\mathrm{JA}}=180^{\circ} \mathrm{C} / \mathrm{W}$ | $\theta_{\mathrm{JC}}=30^{\circ} \mathrm{C} / \mathrm{W}$ |
| AD9698 Ceramic DIP | $\theta_{\mathrm{JA}}=90^{\circ} \mathrm{C} / \mathrm{W}$ | $\theta_{\mathrm{JC}}=25^{\circ} \mathrm{C} / \mathrm{W}$ |
| AD9698 Plastic DIP | $\theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} / \mathrm{W}$ | $\theta_{\mathrm{JC}}=20^{\circ} \mathrm{C} / \mathrm{W}$ |
| AD9698 Plastic SOIC | $\theta_{\mathrm{JA}}=120^{\circ} \mathrm{C} / \mathrm{W}$ | $\theta_{\mathrm{JC}}=20^{\circ} \mathrm{C} / \mathrm{W}$ |

${ }^{3}$ Suffixes KH and TH apply only to model AD9696; AD9698 not available in metal can.
${ }^{4}$ Load circuit has $420 \Omega$ from $+V_{\text {S }}$ to output; $460 \Omega$ from output to ground.
${ }^{5} R_{s} \leq 100 \Omega$.
${ }^{6}$ Propagation delays measured with 100 mV pulse; 10 mV overdrive.
${ }^{7}$ Supply voltages should remain stable within $\pm 5 \%$ for normal operation.
${ }^{8}$ Specification applies to both +5 V and $\pm 5 \mathrm{~V}$ supply operation.
${ }^{9}$ Specification applies to only $\pm 5 \mathrm{~V}$ supply operation.
${ }^{10}$ Measured with nominal values $\pm 5 \%$ of $+V_{\mathrm{S}}$ and $-\mathrm{V}_{\mathrm{s}}$.
${ }^{11}$ Although fall time is faster than rise time, the complementary outputs cross at midpoint of logic swing because of delay on start of falling edge.
Specifications subject to change without notice.

## EXPLANATION OF TEST LEVELS

## Test Level

I - $100 \%$ production tested.
II - $100 \%$ production tested at $+25^{\circ} \mathrm{C}$, and sample tested at specified temperatures.
III - Sample tested only.
IV - Parameter is guaranteed by design and characterization testing.
V - Parameter is a typical value only.
VI - All devices are $100 \%$ production tested at $+25^{\circ} \mathrm{C} .100 \%$ production tested at temperature extremes for extended temperature devices; sample tested at temperature exremes for commercial/industrial devices.

ORDERING GUIDE

| Model | Package | Temperature | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD9696KH | TO-100 Can | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{H}-10 \mathrm{~A}$ |
| AD9696KN | Plastic DIP | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| AD9696KR | SOIC | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | R-8 |
| AD9696KQ | Cerdip | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Q-8 |
| AD9696TH | TO-100 Can | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | H-10A |
| AD9696TQ | Cerdip | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Q-8 |
| AD9696TZ/883B | Gullwing | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Z-8A |
| AD9698KN | Plastic DIP | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| AD9698KR | SOIC | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | R-16A |
| AD9698KQ | Cerdip | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Q-16 |
| AD9698TQ | Cerdip | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Q-16 |
| AD9698TZ/883B | Gullwing | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Z}-16$ |

## NOTES

${ }^{1} H=$ Hermetic Metal Can, $N=$ Plastic DIP, $\mathrm{Q}=$ Cerdip, $\mathrm{R}=$ Small Outline (SOIC), $Z=$ Ceramic Leaded Chip Carrier. For outline information see Package Information section.
${ }^{2}$ Refer to AD9696TZ/883B military data sheet.
${ }^{3}$ Refer to AD9698TZ/883B military data sheet.

## PIN CONFIGURATIONS



PIN DESCRIPTIONS

| Name | Function |
| :---: | :---: |
| Q1 ${ }_{\text {OUT }}$ | One of two complementary outputs. $\mathrm{Q} 1_{\text {out }}$ will be at logic HIGH if voltage at $+\mathrm{IN}_{1}$ is greater than voltage at $-\mathrm{IN}_{1}$ and LATCH ENABLE 1 is at logic LOW. |
| $\overline{\text { Q1 }{ }_{\text {OUT }}}$ | One of two complementary outputs. $\overline{\mathrm{Q}_{\mathrm{OUT}}}$ will be at logic HIGH if voltage at $-\mathrm{IN}_{1}$ is greater than voltage at $+\mathrm{IN}_{1}$ and LATCH ENABLE 1 is at logic LOW. |
| GROUND | Analog and digital ground return. All GROUND pins should be connected together and to a low impedance ground plane near the comparator. |
| LATCH <br> ENABLE 1 | Output at $\mathrm{Q} 1_{\text {OUT }}$ will track differential changes at the inputs when LATCH ENABLE 1 is at logic LOW. When LATCH ENABLE 1 is at logic HIGH, the output at $\mathrm{Q} 1_{\text {OUt }}$ will reflect the input state at the application of the latch command, delayed by the Latch Enable Setup Time ( $\mathrm{t}_{\mathrm{s}}$ ). Since the architecture of the input stage (see block diagram) is faster than the logic of the latch stage, data will typically be latched if applied to the comparator(s) within 1.7 ns after the latch. This is the Setup Time ( $\mathrm{t}_{\mathrm{s}}$ ); for guaranteed performance, $\mathrm{t}_{\mathrm{s}}$ must be 3 ns . |
| N/C | No internal connection to comparator. |
| -V | Negative power supply connection; nominally -5.2 V. |
| $-\mathrm{IN}_{1}$ | Inverting input of differential input stage for Comparator \#1. |
| $+\mathrm{IN}_{1}$ | Noninverting input of differential input stage for Comparator \#1. |
| $+\mathrm{IN}_{2}$ | Noninverting input of differential input stage for Comparator \#2. |
| $-\mathrm{IN}_{2}$ | Inverting input of differential input stage for Comparator \#2. |
| $+\mathrm{V}_{\text {S }}$ | Positive power supply connection; nominally +5 V . |
| LATCH <br> ENABLE 2 | Output at Q2 ${ }_{\text {out }}$ will track differential changes at the inputs when LATCH ENABLE 2 is at logic LOW. When LATCH ENABLE 2 is at logic HIGH, the output at Q2 ${ }_{\text {OUT }}$ will reflect the input state at the application of the latch command, delayed by the Latch Enable Setup Time ( $\mathrm{t}_{\mathrm{s}}$ ). Since the architecture of the input stage (see block diagram) is faster than the logic of the latch stage, data will typically be latched if applied to the comparator(s) within 1.7 ns after the latch. This is the Setup Time ( $\mathrm{t}_{\mathrm{s}}$ ); for guaranteed performance, $\mathrm{t}_{\mathrm{s}}$ must be 3 ns . |
| $\overline{\mathbf{Q 2}_{\text {OUT }}}$ | One of two complementary outputs. $\overline{\mathrm{Q}^{2} \mathrm{OUT}}$ will be at logic HIGH if voltage at $-\mathrm{IN}_{2}$ is greater than voltage at $+\mathrm{IN}_{2}$ and LATCH ENABLE 2 is at logic LOW. |
| Q2out | One of two complementary outputs. $\mathrm{Q}_{2}$ out will be at logic HIGH if voltage at $+\mathrm{IN}_{2}$ is greater than voltage at $-\mathrm{IN}_{2}$ and LATCH ENABLE 2 is at logic LOW. |

## FEATURES

Fast：2．5ns Propagation Delay
Low Power：118mW per Comparator
Packages：DIP，TO－100，SOIC，PLCC
Power Supplies：＋5V，－5．2V
Logic Compatibility：ECL
MIL－STD－883 Versions Available
50ps Delay Dispersion

## APPLICATIONS

High Speed Triggers
High Speed Line Receivers
Threshold Detectors
Window Comparators
Peak Detectors

AD96685 FUNCTIONAL BLOCK DIAGRAM


AD96687 FUNCTIONAL BLOCK DIAGRAM

THE OUTPUTS ARE OPEN EMITTERS，REQUIRING EXTERNAL
PULL－DOWN RESISTORS．THESE RESISTORS MAY BE IN THE RANGE OF 50』－200』 CONNECTED TO－ 2.0 V ，OR 200』－ $2000 \Omega$

The AD96685 and AD96687 are available in both industrial， $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ，and military temperature ranges．Industrial $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ，and military temperature ranges．Industrial
range devices are available in 16－pin DIP，SOIC，and 20－lead PLCC；additionally，the AD96685 is available in a $10-\mathrm{pin}, \mathrm{TO}-100$ metal can．Both devices are available qualified to MIL－STD－883， metal can．Both devices are available qualified to MIL－STD－8
Class B in 16－pin ceramic DIP and 20－lead ceramic LCC；the TO－100 version of the AD96685 is also mil－qualified．


## GENERAL DESCRIPTION

The AD96685 and AD96687 are ultrafast voltage comparators． The AD96685 is a single comparator with 2.5 ns propagation delay；the AD96687 is an equally fast dual comparator．Both devices feature 50 ps propagation delay dispersion which is a particularly important characteristic of high speed comparators． It is a measure of the difference in propagation delay under differing overdrive conditions．
A fast，high precision differential input stage permits consistent propagation delay with a wide variety of signals in the common－ mode range from -2.5 V to +5 V ．Outputs are complementary digital signals fully compatible with ECL 10 K and 10 KH logic families．The outputs provide sufficient drive current to directly drive transmission lines terminated in $50 \Omega$ to -2 V ．A level－ sensitive latch input is included which permits tracking，track－ hold，or sample－hold modes of operation．

ORDERING GUIDE

| Device | Type | Temperature Range | Description | Package <br> Options＊ |
| :--- | :--- | :--- | :--- | :--- |
| AD96685BH | Single | $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 10－Pin Can，Industrial | $\mathrm{H}-10 \mathrm{~A}$ |
| AD96685BP | Single | $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 20－Pin PLCC，Industrial | P－20A |
| AD96685BQ | Single | $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 16－Pin DIP，Industrial | $\mathrm{Q}-16$ |
| AD96685BR | Single | $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 16－Pin SOIC，Industrial | $\mathrm{R}-16$ |
| AD96685TE | Single | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 20－Pin LCC，Extended Temperature | $\mathrm{E}-20 \mathrm{~A}$ |
| AD96685TH | Single | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 10－Pin Can，Extended Temperature | $\mathrm{H}-10 \mathrm{~A}$ |
| AD96685TQ | Single | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 16－Pin DIP，Extended Temperature | $\mathrm{Q}-16$ |
| AD96687BP | Dual | $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 20－Pin PLCC，Industrial | $\mathrm{P}-20 \mathrm{~A}$ |
| AD96687BQ | Dual | $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 16－Pin DIP，Industrial | Q－16 |
| AD96687BR | Dual | $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 16－Pin SOIC，Industrial | $\mathrm{R}-16$ |
| AD96687TE | Dual | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 20－Pin LCC，Extended Temperature | $\mathrm{E}-20 \mathrm{~A}$ |
| AD96687TQ | Dual | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 16－Pin DIP，Extended Temperature | Q－16 |

[^214]This is an abridged data sheet．To obtain the most recent version or complete data sheet，call our fax retrieval system at 1－800－446－6212．


ELECTRICAL CHARACTERISTICS (Positive Supply Voltage $=+5.0 \mathrm{~V}$; Negative Supply Voltage $=-5.2 V$, unless otherwise stated)

| Parameter | Temp | Test <br> Level | Industrial Temp. Range $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ AD96685BH/BQ/BP/BR <br> AD96687BQ/BP/BR |  |  |  |  |  | $\begin{aligned} & \text { Extended Temp. Range }-55^{\circ} \mathrm{C} \text { to }+125^{\circ} \mathrm{C} \\ & \text { AD96685TE/TH/TQ } \end{aligned} \text { AD96687TE/TQ }$ |  |  |  |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max |  | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| INPUTCHARACTERISTICS Input Offset Voltage ${ }^{4}$ | $\begin{aligned} & +25^{\circ} \mathrm{C} \\ & \text { Fuil } \end{aligned}$ |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  |  |  | 1 | 2 |  |  | 2 |  | 1 | 2 |  | 1 | 2 | mV |
|  |  | VI |  |  | 3 |  |  | 3 |  |  | 3 |  |  | 3 | mV |
| Input Offset Drift | Full | V |  | 20 |  |  | 20 |  |  | 20 |  |  | 20 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Bias Current | $+25^{\circ} \mathrm{C}$ | I |  | 7 | 10 |  | 7 | 10 |  | 7 | 10 |  | 7. | 10 | $\mu \mathrm{A}$ |
| $\therefore$ | Full | VI |  |  | 13 |  |  | 13 |  |  | 16 |  |  | 16 | $\mu \mathrm{A}$ |
| Input Offset Current | $+25^{\circ} \mathrm{C}$ | I |  | 0.1 | 1.0 |  | 0.1 | 1.0 |  | 0.1 | 1.0 |  | 0.1 | 1.0 | $\mu \mathrm{A}$ |
|  | Full | VI |  |  | 1.2 |  |  | 1.2 |  |  | 1.2 |  |  | 1.2 | $\mu \mathrm{A}$ |
| Input Resistance | $+25^{\circ} \mathrm{C}$ | V |  | 200 |  |  | 200 |  |  | 200 |  |  | 200 |  | $\mathrm{k} \Omega$ |
| Input Capacitance | $+25^{\circ} \mathrm{C}$ | V |  | 2 |  |  | 2 |  |  | 2 |  |  | 2 |  | pF |
| Input Voltage Ranges | Full | VI | -2.5 |  | $+5.0$ | -2.5 |  | +5.0 | -2.5 |  | +5.0 | -2.5 |  | + 5.0 | V |
| Common-Mode Rejection Ratio | Full | VI | 80 | 90 |  | 80 | 90 |  | 80 | 90 |  | 80 | 90 |  | dB |
| ENABLE INPUT |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| Logic "1" Voltage | Full | VI | $-1.1$ |  |  | -1.1 |  |  | -1.1 |  |  | $-1.1$ |  |  | V |
| Logic " 0 " Voltage | Full | VI |  |  | -1.5 |  |  | $-1.5$ |  |  | -1.5 |  |  | -1.5 | V |
| Logic "l" Current | Full | VI |  |  | 40 |  |  | 40 |  |  | 40 |  |  | 40 | $\mu \mathrm{A}$ |
| Logic "0" Current | Full | VI |  |  | 5 |  |  | 5 |  |  | 5 |  |  | 5 | $\mu \mathrm{A}$ |
| DIGITAL OUTPUTS ${ }^{6}$ |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| Logic " 1 " Voltage | Full | VI | -1.1 |  |  | -1.1 |  |  | -1.1 |  |  | -1.1 |  |  | V |
| Logic "0" Voltage | Full | VI |  |  | -1.5 |  |  | -1.5 |  |  | -1.5 |  |  | -1.5 | V |
| SWITCHING PERFORMANCE ${ }^{6}$ |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| Propagation Delays ${ }^{7}$ |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| Input to Output HIGH | $+25^{\circ} \mathrm{C}$ | IV |  | 2.5 | 3.5 |  | 2.5 | 3.5 |  | 2.5 | 3.5 |  | 2.5 | 3.5 | ns |
| Input to Output LOW | $+25^{\circ} \mathrm{C}$ | IV |  | 2.5 | 3.5 |  | 2.5 | 3.5 |  | 2.5 | 3.5 |  | 2.5 | 3.5 | ns |
| Latch Enable to Output HIGH | $+25^{\circ} \mathrm{C}$ | IV |  | 2.5 | 3.5 |  | 2.5 | 3.5 |  | 2.5 | 3.5 |  | 2.5 | 3.5 | ns |
| Latch Enable to Output LOW | $+25^{\circ} \mathrm{C}$ | IV |  | 2.5 | 3.5 |  | 2.5 | 3.5 |  | 2.5 | 3.5 |  | 2.5 | 3.5 | ns |
| Dispersion ${ }^{8}$ | $+25^{\circ} \mathrm{C}$ | V |  | 50 |  |  | 50 |  |  | 50 |  |  | 50 |  |  |
| Latch Enable |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| Minimum Pulse Width | $+25^{\circ} \mathrm{C}$ | IV |  | 2.0 | 3.0 |  | 2.0 | 3.0 |  | 2.0 | 3.0 |  | 2.0 | 3.0 | ns |
| Minimum Setup Time | $+25^{\circ} \mathrm{C}$ | IV |  | 0.5 | 1.0 |  | 0.5 | 1.0 |  | 0.5 | 1.0 |  | 0.5 | 1.0 | ns |
| Minimum Hold Time | $+25^{\circ} \mathrm{C}$ | IV |  | 0.5 | 1.0 |  | 0.5 | 1.0 |  | 0.5 | 1.0 |  | 0.5 | 1.0 | ns |
| POWER SUPPLY ${ }^{9}$ |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| Positive Supply Current ( +5.0 V ) | Full | VI |  |  | 9 |  |  | 18 |  | 8 | 9 |  | 15 | 18 | mA |
| Negative Supply Current ( -5.2 V ) | Full | VI |  |  | 18 |  | 31 | 36 |  | 15 | 18 |  | 31 | 36 | mA |
| Power Supply Rejection Ratio ${ }^{10}$ | Full | VI | 60 | 70 |  | 60 | 70 |  | 60 | 70 |  | 60 | 70 |  | dB |

## NOTES

${ }^{1}$ Absolute maximum ratings are limiting values, to be applied individually, and beyond which serviceability of the circuit may be impaired. Functional operation under any of these conditions is not necessarily implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ Under no circumstances should the input voltages exceed the supply . voltages.
${ }^{3}$ Typical thermal impedances . .
AD96685 Metal Can $\quad \theta_{\mathrm{JA}}=172^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=52^{\circ} \mathrm{C} / \mathrm{W}$
AD96685 Ceramic $\quad \theta_{\mathrm{JA}}=115^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=57^{\circ} \mathrm{C} / W$
$\mathrm{AD} 96685 \mathrm{LCC} \quad \therefore \quad \theta_{\mathrm{JA}}=172^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=65^{\circ} \mathrm{C} / \mathrm{W}$
AD96685 SOIC $\quad \theta_{\mathrm{JA}}=170^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JO}}=60^{\circ} \mathrm{C} / \mathrm{W}$
AD96685 PLCC $\quad \theta_{\mathrm{JA}}=88^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=45^{\circ} \mathrm{C} / \mathrm{W}$
AD96687 Ceramic $\quad \theta_{\mathrm{JA}}=115^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=57^{\circ} \mathrm{C} / \mathrm{W}$
AD96687 LCC
AD96687 SOIC
AD96687 PLCC
$\theta_{\mathrm{JA}}=82^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=31^{\circ} \mathrm{C} / \mathrm{W}$
$\theta_{\mathrm{JA}}=92^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=47^{\circ} \mathrm{C} / \mathrm{W}$
$\theta_{\mathrm{JA}}=81^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=45^{\circ} \mathrm{C} / \mathrm{W}$
${ }^{4} \mathrm{R}_{\mathrm{s}}=100 \Omega$.
${ }^{5}$ Input Voltage Range can be extended to -3.3 V if $-\mathrm{V}_{\mathrm{s}}=-6.0 \mathrm{~V}$.
${ }^{6}$ Outputs terminated through $50 \Omega$ to -2.0 V .
${ }^{7}$ Propagation delays measured with 100 mV pulse ( 10 mV overdrive), to $50 \%$ transition point of the output.
${ }^{8}$ Change in propagation Delay from 100 mV to 1 V input overdrive.
${ }^{9}$ Supply voltages should remain stable within $\pm 5 \%$ for normal operation.
${ }^{10}$ Measured at $\pm 5 \%$ of $+V_{\mathrm{s}}$ and $-V_{\mathrm{s}}$.
Specifications subject to change without notice.

## EXPLANATION OF TEST LEVELS

## Test Level

I - $100 \%$ production tested.
II - $100 \%$ production tested at $+25^{\circ} \mathrm{C}$, and sample tested at specified temperatures.
III - Sample tested only.
IV - Parameter is guaranteed by design and characterization testing.
V - Parameter is a typical value only.
VI - All devices are $100 \%$ production tested at $+25^{\circ} \mathrm{C}$; $100 \%$ production tested at temperature extremes for extended temperature devices; sample tested at temperature extremes for commercial/industrial devices.

## FUNCTIONAL DESCRIPTION

Pin Name
$+\mathrm{V}_{\mathrm{s}} \quad$ - Positive supply terminal, nominally +5.0 V .
NONINVERTING INPUT
INVERTING INPUT
LATCH ENABLE

LATCH ENABLE
$-V_{s}$
Q
$\bar{Q}$

GROUND 1
GROUND 2 be driven in conjunction with the INVERTING INPUT. in conjunction with the NONINVERTING INPUT. ENABLE for the AD96687. LATCH ENABLE for the AD96687.

- Negative supply terminal, nominally -5.2V only) for additional information. only) for additional information. connected together near the comparator.

Description

- Noninverting analog input of the differential input stage. The NONINVERTING INPUT must
- Inverting analog input of the differential input stage. The INVERTING INPUT must be driven
- In the "compare" mode (logic HIGH), the output will track changes at the input of the comparator. In the "latch" mode (logic LOW), the output will reflect the input state just prior to the comparator being placed in the "latch" mode. LATCH ENABLE must be driven in conjunction with LATCH
- In the "compare" mode (logic LOW), the output will track changes at the input of the comparator. In the "latch" mode (logic HIGH), the output will reflect the input state just prior to the comparator being placed in the "latch" mode. LATCH ENABLE must be driven in conjunction with
- One of two complementary outputs. Q will be at logic HIGH if the analog voltage at the NONINVERTING INPUT is greater than the analog voltage at the INVERTING INPUT (provided the comparator is in the "compare" mode). See LATCH ENABLE and LATCH ENABLE (AD96687
- One of two complementary outputs. $\bar{Q}$ will be at logic LOW if the analog voltage at the NONINVERTING INPUT is greater than the analog voltage at the INVERTING INPUT (provided the comparator is in the "compare" mode). See LATCH ENABLE and LATCH ENABLE (AD96687
- One of two grounds, but primarily associated with the digital ground. Both grounds should be
- One of two grounds, but primarily associated with the analog ground. Both grounds should be connected together near the comparator.

PIN DESIGNATIONS


## FEATURES

- High Gain

200V/mV Typ

- Single or Dual Supply Operation
- Input Voltage Range Includes Ground
- Low Power Consumption ( $1.5 \mathrm{~mW} /$ Comparator)
- Low Input Bias Current ....................... . 100nA Max
- Low Input Offset Current . . . . . . . . . . . . . . . . . . . . 10nA Max
- Low Offset Voltage ............................... . 1 mV Max
- Low Output Saturation Voltage ......... 250mV @ 4mA
- Logic Output Compatible with TTL, DTL, ECL, MOS and CMOS
- Directly Replaces LM139/239/339 Comparators
- Available in Die Form


## ORDERING INFORMATION ${ }^{\dagger}$

| $\begin{gathered} T_{A}=+25^{\circ} \mathrm{C} \\ V_{O S} \\ (\mathrm{mV}) \end{gathered}$ | PACKAGE |  |  | OPERATING TEMPERATURE RANGE |
| :---: | :---: | :---: | :---: | :---: |
|  | CERDIP <br> 14-PIN | PLASTIC 14-PIN | $\begin{gathered} \text { SO } \\ \text { 14-PIN } \end{gathered}$ |  |
| 1 | CMP04BY* | - | - | MIL |
| 1 | CMP04FY | CMP04FP | CMP04FS | XIND |

* For devices processed in total compliance to MIL-STD-883, add/883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.

SIMPLIFIED SCHEMATIC (1/4 CMP-04)


## GENERAL DESCRIPTION

Four precision independent comparators comprise the CMP04. Performance highlights include a very low offset voltage, low output saturation voltage and high gain in a single supply design. The input voltage range includes ground for single supply operation and $V$ - for split supplies. A low power supply current of 2 mA , which is independent of supply voltage, makes this the preferred comparator for precision applications requiring minimal power consumption. Maximum logic interface flexibility is offered by the open-collector TTL output.

## PIN CONNECTIONS



## TYPICAL INTERFACE



This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.


Output Short-Circuit to GND .................................. Continuous
Lead Temperature (Soldering, 60 sec ) ........................... $300^{\circ} \mathrm{C}$

| PACKAGE TYPE | $\boldsymbol{\theta}_{\text {jA }}($ Note 2) | $\boldsymbol{\theta}_{\text {Ic }}$ | UNITS |
| :--- | :---: | :---: | :---: |
| 14-Pin Hermetic DIP $(Z)$ | 110 | 26 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 14-Pin Plastic DIP $(P)$ | 83 | 39 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 14-Pin SO $(\mathrm{S})$ | 120 | 36 | ${ }^{\circ} \mathrm{CW}$ |

NOTES:

1. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
2. $\Theta_{j A}$ is specified for worst case mounting conditions, i.e., $\Theta_{j A}$ is specified for device in socket for CerDIP and P-DIP packages; $\Theta_{j A}$ is specified for device soldered to printed circuit board for SO package.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}+=+5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | CMP-04B/F |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX |  |
| Input Offset Voltage | $\mathrm{V}_{\text {os }}$ | $\begin{aligned} & R_{S}=0 \Omega, R_{L}=5.1 \mathrm{k} \Omega \\ & V_{O}=1.4 \mathrm{~V},(\text { Note } 1) \end{aligned}$ | - | 0.4 | 1 | mV |
| Input Offset Current | Ios | $\begin{aligned} & I_{\mathbb{I N}^{\prime}}(+)-!_{\mathbb{N}^{( }(-)} \\ & R_{\mathrm{L}}=5.1 \mathrm{k} \Omega \\ & \mathrm{~V}_{\mathrm{O}}=1.4 \mathrm{~V} \end{aligned}$ | - | 2 | 10 | nA |
| Input Bias Current | $I_{B}$ | $\mathrm{I}_{\mathbb{N}^{( }}(+)$or $\mathrm{I}_{\mathbb{N}^{(-)}}$ | - | 25 | 100 | nA |
| Voltage Gain | $A_{V}$ | $R_{L} \geq 15 \mathrm{k} \Omega, \mathrm{V}+=15 \mathrm{~V}$, (Note 5) | 80 | 200 | - | $\mathrm{V} / \mathrm{mV}$ |
| Large-Signal Response Time | $t_{r}$ | $\begin{aligned} & V_{I N}=\text { TTL Logic Swing } \\ & V_{\text {REF }}=1.4 \mathrm{~V},(\text { Note } 4) \\ & V_{\text {RL }}=5 \mathrm{~V}, R_{\mathrm{L}}=5.1 \mathrm{k} \Omega \end{aligned}$ | - | 300 | - | ns |
| Small-Signal Response Time | $\mathrm{t}_{\mathrm{r}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=100 \mathrm{mV} \text { Step, (Note 4) } \\ & 5 \mathrm{mV} \text { Overdrive } \\ & \mathrm{V}_{\mathrm{RL}}=5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=5.1 \mathrm{k} \Omega \\ & \hline \end{aligned}$ | - | 1.3 | - | $\mu \mathrm{S}$ |
| Input Voltage Range | CMVR | (Note 2) | 0 | - | $\mathrm{V}+-1.5$ | V |
| Common-Mode Rejection Ratio | CMRR | (Notes 3, 5) | 80 | 100 | - | dB |
| Power Supply Rejection Ratio | PSRR | $\mathrm{V}+=+5 \mathrm{~V}$ to 18V, (Note 5) | 80 | 100 | - | dB |
| Saturation Voltage | $\mathrm{V}_{\mathrm{OL}}$ | $\begin{aligned} & \mathrm{V}_{\mathbb{N}}(-) \geq 1 \mathrm{~V}, \mathrm{~V}_{\mathbf{I N}}(+)=0, \\ & \mathrm{I}_{\mathrm{SINK}} \leq 4 \mathrm{~mA} \end{aligned}$ | - | 250 | 400 | mV |
| Output Sink Current | ${ }^{\text {S Sink }}$ | $\begin{aligned} & V_{I N}(-) \geq 1 \mathrm{~V}, \\ & V_{I N}(+)=0, V_{O} \leq 1.5 \mathrm{~V} \end{aligned}$ | 6 | 16 | - | mA |
| Output Leakage Current | $I_{\text {leak }}$ | $\begin{aligned} & V_{I N}(+) \geq 1 V \\ & V_{I_{N}}(-)=0, V_{O}=30 \mathrm{~V} \end{aligned}$ | - | 0.1 | 100 | nA |
| Supply Current | $1+$ | $\begin{aligned} & \mathbf{R}_{\mathbf{L}}=\infty, \text { All Comps } \\ & \mathbf{V}+=30 \mathrm{~V} \end{aligned}$ | - | 0.8 | 2.0 | mA |

## NOTES:

1. At output switch point, $\mathrm{V}_{\mathrm{O}}=1.4 \mathrm{~V}, \mathrm{R}_{\mathrm{S}}=0 \Omega$ with $\mathrm{V}+$ from 5 V ; and over the full input common-mode range ( $O \mathrm{~V}$ to $\mathrm{V}+-1.5 \mathrm{~V}$ ).
2. The input common-mode voltage or either input signal voltage should not be allowed to go negative by more than 0.3 V . The upper end of the common-mode voltage range is $\mathrm{V}+-1.5 \mathrm{~V}$, but either or both inputs can go to +30 V without damage.
3. $\mathrm{R}_{\mathrm{L}} \geq 15 \mathrm{k} \Omega, \mathrm{V}+=15 \mathrm{~V}, \mathrm{~V}_{\mathrm{CM}}=1.5 \mathrm{~V}$ to 13.5 V .
4. Sample tested.
5. Guaranteed by design.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}+=+5 \mathrm{~V},-55^{\circ} \mathrm{C} \leq T_{A} \leq+125^{\circ} \mathrm{C}$ for CMP-04BY, $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{A} \leq+85^{\circ} \mathrm{C}$ for CMP-04FY/RP/ FS, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | CMP-04B/FMIN (Note 3) MYP MAX UNITS |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input Offset Voltage | $\mathrm{V}_{\mathrm{OS}}$ | $\begin{aligned} & R_{\mathrm{S}}=0 \Omega, R_{\mathrm{L}}=5.1 \mathrm{k} \Omega \\ & V_{\mathrm{O}}=1.4 \mathrm{~V},(\text { Note } 1) \end{aligned}$ | - | 1 | 2 | $\cdots \mathrm{mV}$ |
| Input Offset Current | Ios | $\begin{aligned} & I_{\mathbb{N}}(+)-I_{N}(-) \\ & R_{\mathrm{L}}=5.1 \mathrm{k} \Omega \\ & V_{\mathrm{O}}=1.4 \mathrm{~V} \end{aligned}$ | - | 4 | $\therefore 20$ | nA |
| Input Bias Current,$\therefore \quad \therefore$ | $I_{B}$ | $\mathrm{I}_{\text {IN }}(+)$ or $\mathrm{I}_{\text {IN }}(-)$ | - | 40 | +200 | nA |
| Voltage Gain | $A_{V}$ | $R_{\mathrm{L}} \geq 15 \mathrm{k} \Omega, \mathrm{V}+=15 \mathrm{~V}$, (Note 5) | 70 | 125 | - | $\mathrm{V} / \mathrm{mV}$ |
| Large-Signal Response Time | $\mathrm{t}_{\mathrm{r}}$ | $\begin{aligned} & V_{\mathbb{N}}=T T L \text { Logic Swing } \\ & V_{R E F}=1.4 \mathrm{~V},(\text { Note 4) } \\ & V_{\mathrm{RL}}=5 \mathrm{~V}_{i} R_{\mathrm{L}}=5.1 \mathrm{k} \Omega \end{aligned}$ |  | 300 |  | ns |
| Small-Signal Response Time | $\mathrm{t}_{\mathrm{r}}$ | $\begin{aligned} & V_{1 \mathrm{~N}}=100 \mathrm{mV} \text { Step, (Note 4) } \\ & 5 \mathrm{mV} \text { Overdrive } \\ & \mathrm{V}_{\mathrm{RL}}=5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=5.1 \mathrm{k} \Omega \\ & \hline \end{aligned}$ | - | - 1.3 | - - | $\cdots \mathrm{ss}$ |
| Input Voltage Range | CMVR | (Note 2) | 0 | - | $\mathrm{V}+-1.5$ | V |
| Common-Mode Rejection Ratio | CMRR | (Notes 3, 5) | 60 | 100 | - | dB |
| Power Supply Rejection Ratio | PSRR | $\mathrm{V}+=+5 \mathrm{~V}$ to 18 V | 80 | 100 | - | dB |
| Saturation Voltage | $\mathrm{V}_{\mathrm{OL}}$ | $\begin{aligned} & V_{\mathbb{N N}^{\prime}(-) \geq 1 \mathrm{~V}, \mathrm{~V}_{\mathrm{IN}}(+)=0,} \\ & \mathrm{I}_{\text {SINK }} \leq 4 \mathrm{~mA} \end{aligned}$ | - | 250 | 700 | mV |
| Output Sink Current | $I_{\text {SINK }}$ | $\begin{aligned} & V_{\mathbb{N N}^{(-)}} \geq 1 \mathrm{~V}, \\ & \mathrm{~V}_{\mathbf{I N}}(+)=0, \mathrm{~V}_{\mathrm{O}} \leq 1.5 \mathrm{~V} \end{aligned}$ | 5 | 16 | - | mA |
| Output Leakage Current ... | ILeak | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}^{(+)}} \geq 1 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{IN}^{(-)}}=0, \mathrm{~V}_{\mathrm{O}}=30 \mathrm{~V} \end{aligned}$ | - | 0.1 | 200 | nA |
| Supply Current | I+ | $\begin{aligned} & R_{L}=\infty, \text { All Comps } \\ & \mathrm{V}+=30 \mathrm{~V} \end{aligned}$ | - | 1.2 | 3.0 | $\because \quad m A$ |

## NOTES:

1. At output switch point, $\mathrm{V}_{\mathrm{O}}=1.4 \mathrm{~V}, \mathrm{R}_{\mathrm{S}}=0 \Omega$ with $\mathrm{V}+$ from 5 V ; and over the full input common-mode range ( OV to $\mathrm{V}+-1.5 \mathrm{~V}$ ).
2. The input common-mode voltage or either input signal voltage should not be allowed to go negative by more than 0.3 V . The upper end of the common-mode voltage range is $\mathrm{V}+-1.5 \mathrm{~V}$, but either or both inputs can go to +30 V without damage.

## BURN-IN CIRCUIT


3. $R_{\mathrm{L}} \geq 15 \mathrm{k} \Omega, \mathrm{V}+=15 \mathrm{~V}, \mathrm{~V}_{\mathrm{CM}}=1.5 \mathrm{~V}$ to 13.5 V .
4. Sample tested.
5. Guaranteed by design.

# Matched Transistors Contents 

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Selection Tree - Matched Transistors


## Selection Guide-Matched Transistors

| Model | Type | $\begin{aligned} & \mathbf{V} \text { os }^{\text {Max }} \\ & \boldsymbol{\mu \mathrm { V }} \end{aligned}$ | $\mathrm{TCV}_{\text {os }}$ Max $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ | $\begin{aligned} & \text { hFE } \\ & \mathbf{M i n}^{1} \end{aligned}$ | $\begin{aligned} & \Delta \mathrm{hFE} \\ & \max _{\%} \end{aligned}$ | en <br> max <br> $\mathrm{nV} / \sqrt{\mathbf{H z}^{2}}$ | Package Options ${ }^{3}$ | Temp Ranges ${ }^{4}$ | Comments | Page ${ }^{5}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| MAT01 | Dual NPN | 100 | 0.5 | 500 | 3 | 7.5 | Q | M/ | Low Cost | 13-5 |
| MAT02 | Dual NPN | 50 | 0.1 | 500 | 2 | 1 | N | I, M/ | Low Noise, Low $\mathrm{r}_{\text {be }}$ | 13-7 |
| mat03 | Dual PNP | 100 | 0.5 | 100 | 2 | 1 | N | I, M/ | Low Noise | 13-10 |
| MAT04 | Quad NPN | 200 | 1 | 300 | 2 | 2.5 | N | I, M/ | Low Cost | 13-13 |
| SSM2210 | Dual NPN | 200 | 1 | 300 | 5 | 1 | P | I | Low Cost, Audio | D |
| SSM2220 | Dual PNP | 200 | 1 | 80 | 6 | 1 | R | I | Low Cost, Audio | D |

${ }^{1} \mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}$
${ }^{2} \mathrm{f}_{\mathrm{C}} \geq 100 \mathrm{~Hz}$



 temperature designator will be followed by: / to indicate 883 B , ${ }_{\mathrm{J}}$ for JAN, ${ }_{\mathrm{D}}$ for SMD, and ${ }_{\mathrm{s}}$ for space level.
${ }^{5} \mathrm{D}=$ Data Sheet. All other entries refer to this volume.
Boldface Type: Data sheet information in this volume.

| FEATURES |  |
| :---: | :---: |
|  |  |
| Low TCVos | $0.5 \mu \mathrm{~V} /{ }^{\text {C }} \mathrm{C}$ Max |
| - High hfe . ................................ 500 Min |  |
| - Excellent $h_{\text {FE }}$ Linearity from 10 nA to 10 mA |  |
| - Low Noise Voltage ......... $0.23 \mu \mathrm{~V}$ p-p $-\mathbf{0 . 1 H z}$ to 10 Hz |  |
|  |  |
| - Available in Die Form |  |

## ORDERING INFORMATION $\dagger$

| $\mathbf{T}_{\mathbf{A}}=25^{\circ} \mathbf{C}$ <br> $\mathbf{V}_{\mathbf{O S} \text { MAX }}$ <br> $(\mathrm{mV})$ | PACKAGE | OPERATING <br> TEMPERATURE <br> RANGE |
| :---: | :---: | :---: |
| 0.1 | MAT01AH $^{*}$ | MIL |
| 0.5 | MAT01GH | MIL |

* For devices processed in total compliance to MIL-STD-883, add/883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.


## GENERAL DESCRIPTION

The MAT-01 is a monolithic dual NPN transistor. An exclusive Silicon Nitride "Triple-Passivation" process provides excellent stability of critical parameters over both temperature and time. Matching characteristics include offset voltage of $40 \mu \mathrm{~V}$, temperature drift of $0.15 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$, and $\mathrm{h}_{\mathrm{FE}}$ matching of $0.7 \%$. Very high $\mathrm{h}_{\text {FE }}$ is provided over a six decade range of collector current, including an exceptional $h_{\text {FE }}$ of 590 at a collector current of only 10 nA . The high gain at low collector current makes the MAT-01 ideal for use in low-power, low-level input stages.

## PIN CONNECTIONS



This is an abridged data sheet. To obtain the most recent version or
complete data sheet, call our fax retrieval system at $1-800-446-6212$.


ELECTRICAL CHARACTERISTICS at $V_{C B}=15 \mathrm{~V}, I_{C}=10 \mu \mathrm{~A}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.

|  |  |  | MAT-01AH |  |  | MAT-01GH |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Breakdown Voltage | $\mathrm{BV}_{\text {CEO }}$ | $\mathrm{I}_{\mathrm{C}}=100 \mu \mathrm{~A}$ | 45 | - | - | 45 | - | - | V |
| Offset Voltage | $\mathrm{V}_{\text {OS }}$ |  | - | 0.04 | 0.1 | - | 0.10 | 0.5 | mV |
| Offset Voltage Stability <br> First Month Long-Term | $\mathrm{V}_{\mathrm{OS}} /$ Time | (Note 1) <br> (Note 2) | - | $\begin{aligned} & 2.0 \\ & 0.2 \end{aligned}$ | - | - | 2.0 0.2 | - | $\mu \mathrm{V} / \mathrm{Mo}$ |
| Offset Current | Ios |  | - | 0.1 | 0.6 | - | 0.2 | 3.2 | nA |
| Bias Current | $\mathrm{I}_{\mathrm{B}}$ |  | - | 13 | 20 | - | 18 | 40 | nA |
|  |  | $I_{C}=10 \mathrm{nA}$ | - | 590 | - | - | 430 | - |  |
| Current Gain | $\mathbf{h F E}^{\text {F }}$ | $I_{C}=10 \mu \mathrm{~A}$ | 500 | 770 | - | 250 | 560 | - |  |
|  |  | $I_{C}=10 \mathrm{~mA}$ | - | 840 | - | - | 610 | - | \% |
| Current Gain Match | $\Delta \mathrm{h}_{\text {FE }}$ | $\mathrm{I}_{\mathrm{C}}=10 \mu \mathrm{~A}$ | - | 0.7 | 3.0 | - | 1.0 | 8.0 | \% |
| Current Gain Match | $\Delta h_{\text {FE }}$ | $100 \mathrm{nA} \leq \mathrm{I}_{\mathrm{C}} \leq 10 \mathrm{~mA}$ | - | 0.8 | - | - | 1.2 | - | \% |
| Low Frequency Noise Voltage | $e_{\text {np-p }}$ | 0.1 Hz to 10 Hz (Note 3): | - | 0.23 | 0.4 | - | 0.23 | 0.4 | $\mu V_{p-p}$ |
| Broadband Noise Voltage | $e_{\text {nRMS }}$ | 1 Hz to 10 kHz | - | 0.60 | - | - | 0.60 | - | $\mu \mathrm{V}_{\text {RMS }}$ |
|  |  | $\mathrm{f}_{\mathrm{O}}=10 \mathrm{~Hz}$ (Note 3) | - | 7.0 | 9.0 | - | 7.0 | 9.0 |  |
| Density | $e_{n}$ | $\mathrm{f}^{\mathrm{O}}=100 \mathrm{~Hz}$ (Note 3) | - | 6.1 | 7.6 | - | 6.1 | 7.6 | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
|  |  | $\mathrm{f}_{\mathrm{O}}=1000 \mathrm{~Hz}$ (Note 3) | - | 6.0 | 7.5 | - | 6.0 | 7.5 |  |
| Offset Voltage Change | $\Delta V_{\text {OS }} / \Delta V_{\text {CB }}$ | $0 \leq \mathrm{V}_{\mathrm{CB}} \leq 30 \mathrm{~V}$ | - | 0.5 | 3.0 | - | 0.8 | 8.0 | $\mu \mathrm{V} / \mathrm{V}$ |
| Offset Current Change | $\Delta l_{\text {OS }} / \Delta V_{\text {CB }}$ | $0 \leq \mathrm{V}_{\mathrm{CB}} \leq 30 \mathrm{~V}$ | - | 2 | 15 | - | 3 | 70 | pA/V |
| Collector-Base <br> Leakage Current | $\mathrm{I}_{\text {CBO }}$ | $\begin{aligned} & V_{C B}=30 \mathrm{~V}, \mathrm{I}_{\mathrm{E}}=0 \\ & \text { (Note 4) } \end{aligned}$ | - | 15 | 50 | - | 25 | 200 | pA |
| Collector-Emitter Leakage Current | $I_{\text {CES }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{CE}}=30 \mathrm{~V}, \mathrm{~V}_{\mathrm{BE}}=0 \\ & (\text { Notes 4, 6) } \end{aligned}$ | - | 50 | 200 | - | 90 | 400 | pA |
| Collector-Collector Leakage Current | Icc | $\mathrm{V}_{\mathrm{CC}}=30 \mathrm{~V}$, (Note 6) | - | 20 | 200 | - | 30 | 400 | pA |
| Collector Saturation Voltage | $V_{\text {CE (SAT }}$ | $\begin{aligned} & I_{B}=0.1 \mathrm{~mA}, I_{C}=1 \mathrm{~mA} \\ & I_{B}=1 \mathrm{~mA}, I_{C}=10 \mathrm{~mA} \end{aligned}$ | - | $\begin{array}{r} 0.12 \\ 0.8 \end{array}$ | 0.20 | - | $\begin{array}{r} 0.12 \\ 0.8 \\ \hline \end{array}$ | 0.25 - | V |
| Gain-Bandwidth Product | $\mathrm{f}_{\mathrm{T}}$ | $V_{C E}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=10 \mathrm{~mA}$ | - | 450 | - | - | 450 | - | MHz |
| Output Capacitance | $\mathrm{C}_{\text {ob }}$ | $V_{C B}=15 \mathrm{~V}, \mathrm{I}_{\mathrm{E}}=0$ | - | 2.8 | - | - | 2.8 | - | pF |
| Collector-Collector Capacitance | $\mathrm{C}_{\text {cc }}$ | $\mathrm{V}_{\mathrm{CC}}=0$ | - | 8.5 | - | - | 8.5 | - | pF |

ELECTRICAL CHARACTERISTICS at $V_{C B}=15 V, I_{C}=10 \mu A,-55^{\circ} \mathrm{C} \leq T_{A} \leq+125^{\circ} \mathrm{C}$, unless otherwise noted.

|  |  |  | MAT-01AH |  |  | MAT-01GH |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | MIN | TYP | MAX | UNITS |
| Offset Voltage | $\mathrm{V}_{\text {OS }}$ |  | - | 0.06 | 0.15 | - | 0.14 | 0.70 | mV |
| Average Offset Voltage Drift | $\mathrm{TCV}_{\text {OS }}$ | (Note 7) | - | 0.15 | 0.50 | - | 0.35 | 1.8 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Offset Current | Ios |  | - | 0.9 | 8.0 | - | 1.5 | 15.0 | nA |
| Average Offset Current Drift | $\mathrm{TCl}_{\text {OS }}$ | (Note 5) | - | 10 | 90 | - | 15 | 150 | $\mathrm{pA} /{ }^{\circ} \mathrm{C}$ |
| Bias Current | $I_{B}$ |  | - | 28 | 60 | - | 36 | 130 | nA |
| Current Gain | $h_{\text {FE }}$ |  | 167 | 400 | - | 77 | 300 | - |  |
| Collector-Base Leakage Current | ${ }^{\text {cbo }}$ | $\begin{aligned} & T_{A}=125^{\circ} \mathrm{C}, \mathrm{~V}_{\mathrm{CB}}=30 \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{E}}=0(\text { Note } 4) \end{aligned}$ | - | 15 | 80 | - | 25 | 200 | nA |
| Collector-Emitter Leakage Current | $I_{\text {ces }}$ | $\begin{aligned} & T_{A}=125^{\circ} \mathrm{C}, \mathrm{~V}_{\mathrm{CE}}=30 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{BE}}=0(\text { Notes } 4,6) \end{aligned}$ | - | 50 | 300 | - | 90 | 400 | $n \mathrm{~A}$ |
| Collector-Collector Leakage Current | Icc | $T_{A}=125^{\circ} \mathrm{C}, \mathrm{~V}_{\mathrm{CC}}=30 \mathrm{~V}$ <br> (Note 6) | - | 30 | 200 | - | 50 | 400 | nA |

## FEATURES

- Low Offset Voltage . . . . . . . . . . . . . . . . . . . . . . . . 50 $\sqrt{\mathrm{V} V}$ Max
- Low Noise Voltage at $100 \mathrm{~Hz}, 1 \mathrm{~mA} \ldots$... $1.0 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ Max
- High Gain (hre) . . . . . . . . . . . . . . . . . . 500 Min at $\mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}$

300 min at $c=$

- Excellent Log Conformance .................. $\mathrm{r}_{\mathrm{BE}} \simeq 0.3 \Omega$
- Low Offset Voltage Drift . . . . . . . . . . . . . . . $0.1 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ Max
- Improved Direct Replacement for LM194/394
- Available in Die Form


## ORDERING INFORMATION ${ }^{\dagger}$

| $\begin{gathered} \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ \mathrm{~V}_{\text {OS }} \mathrm{MAX} \\ (\mu \mathrm{~V}) \end{gathered}$ | PACKAGE |  | OPERATING TEMPERATURE RANGE |
| :---: | :---: | :---: | :---: |
|  | TO-78 | $\frac{\text { LCC }}{20-\text { CONTACT }}$ |  |
| 50 | MAT02AH* | - | MIL |
| 50 | MAT02EH | - | IND |
| 150 | - | MAT02BRC/883 | MIL |
| 150 | MAT02FH | - | IND |

* For devices processed in total compliance to MIL-STD-883, add/883 after part number. Consult factory for $\mathbf{8 8 3}$ data sheet.
$t$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.


## GENERAL DESCRIPTION

The design of the MAT-02 series of NPN dual monolithic transistors is optimized for very low noise, low drift, and low $r_{\text {BE }}$. Precision Monolithics' exclusive Silicon Nitride "TriplePassivation" process stabilizes the critical device parameters over wide ranges of temperature and elapsed time. Also, the high current gain ( $\mathrm{h}_{\mathrm{FE}}$ ) of the MAT-02 is maintained over a wide range of collector current. Exceptional characteristics of the MAT-02 include offset voltage of $50 \mu \mathrm{~V} \max$ (A/E grades) and $150 \mu \mathrm{~V}$ max ( $B / F$ grades). Device performance is specified over the full military temperature range as well as at $25^{\circ} \mathrm{C}$.

Input protection diodes are provided across the emitter-base junctions to prevent degradation of the device characteristics due to reverse-biased emitter current. The substrate is clamped to the most negative emitter by the parasitic isolation junction created by the protection diodes. This results in complete isolation between the transistors.
The MAT-02 should be used in any application where low noise is a priority. The MAT-02 can be used as an input stage to make an amplifier with noise voltage of less than $1.0 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ at 100 Hz . Other applications, such as log/anti-log circuits, may use the excellent logging conformity of the MAT-02. Typical bulk resistance is only $0.3 \Omega$ to $0.4 \Omega$. The MAT-02 electrical characteristics approach those of an ideal transistor when operated over a collector current range of $1 \mu A$ to 10 mA . For applications requiring multiple devices see MAT-04 Quad Matched Transistor data sheet.

## PIN CONNECTIONS



T0-78 (H-Suffix)


MAT-02BRC/883 20-LEAD LCC (RC-Suffix)

NOTE: Substrate is connected to case on TO-78 package. Substrate is normally connected to the most negative circuit potential, but can be floated.
ABSOLUTE MAXIMUM RATINGS (Note 3)
Collector-Base Voltage ( $\mathrm{BV}_{\mathrm{CBO}}$ ) ..... 40 V
Collector-Emitter Voltage ( $\mathrm{BV} \mathrm{CEO}_{\text {}}$ ) ..... 40 V
Collector-Collector Voltage (BVCC) ..... 40 V
Emitter-Emitter Voltage ( $\mathrm{BV} \mathrm{EE}_{\mathrm{EE}}$ ) ..... 40 V
Collector Current (IC) ..... 20 mA
Emitter Current ( $\mathrm{I}_{\mathrm{E}}$ ) ..... 20 mA
Total Power Dissipatlon
Case Temperature $\leq 40^{\circ} \mathrm{C}$ (Note 1) ..... 1.8W
Ambient Temperature $\leq 70^{\circ} \mathrm{C}$ (Note 2) ..... 500 mW
Operating Temperature Range
MAT-02E, F
MAT-02A, B
MAT-02A, B $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
$-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
mperature ..... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Storage Temperature
Storage Temperature
$+300^{\circ} \mathrm{C}$
$+300^{\circ} \mathrm{C}$
Junction Temperature $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
NOTES:

1. Rating applies to applications using heat sinking to control case temperature. Derate linearly at $16.4 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ for case temperature above $40^{\circ} \mathrm{C}$.
2. Rating applies to applications not using heat sinking; device in free air only. Derate linearly at $6.3 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ for ambient temperature above $70^{\circ} \mathrm{C}$.
3. Absolute maximum ratings apply to both DICE and packaged devices.

## MAT02

ELECTRICAL CHARACTERISTICS at $V_{C B}=15 \mathrm{~V}, I_{C}=10 \mu \mathrm{~A}, \mathrm{~T}_{A}=25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | MAT-02AE |  |  | MAT-02B/F |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Current Gain | $h_{\text {fe }}$ | $\begin{aligned} & I_{C}=1 \mathrm{~mA} \quad \text { (Note 1) } \\ & I_{C}=100 \mu A \\ & I_{C}=10 \mu A \\ & I_{C}=1 \mu A \end{aligned}$ | 500 | 605 | - | 400 | 605 | - | \% |
|  |  |  | 500 | 590 | - | 400 | 590 |  |  |
|  |  |  | 400 | 550 | - | 300 | 550 |  |  |
|  |  |  | 300 | 485 | - | 200 | 485 |  |  |
| Current Gain Match | $\Delta h_{\text {fe }}$ | $10 \mu A \leq I_{C} \leq 1 m A$, (Note 2) | - | 0.5 | 2 | - | 0.5 | 4 |  |
| Offset Voltage | $\mathrm{V}_{\mathrm{OS}}$ | $\begin{aligned} & V_{C B}=0 \\ & 1 \mu A \leq I_{C} \leq 1 \mathrm{~mA}(\text { Note } 7) \end{aligned}$ | - | 10 | 50 | - | 80 | 150 | $\therefore \mu \mathrm{V}$ |
| Offset Voltage Change vs $\mathrm{V}_{\mathrm{CB}}$ | $\Delta \mathrm{V}_{\mathrm{OS}} / \Delta \mathrm{V}_{\mathrm{CB}}$ | $\begin{aligned} & 0 \leq V_{C B} \leq V_{M A X}(\text { Note } 6) \\ & 1 \mu A \leq I_{C} \leq 1 \text { mA }(\text { Note } 7) \end{aligned}$ | - | 10 | 25 | - | 10 | 50 | $\mu \mathrm{V}$ |
| Offset Voltage Change vs. Collector Current | $\Delta \mathrm{V}_{\text {OS }} / \Delta \mathrm{l}_{\mathrm{C}}$ | $\begin{aligned} & V_{C B}=0 V \\ & 1_{\mu \mathrm{A}} \leq I_{C} \leq 1 \mathrm{~mA}(\text { Note } 7) \end{aligned}$ | - | 5 | 25 | - | 5 | 50 | $\mu \mathrm{V}$ |
| Offset Current Change vs $\mathrm{V}_{\mathrm{CB}}$ | $\Delta \mathrm{los}^{\prime} / \Delta \mathrm{V}_{\mathrm{CB}}$ | $0 \leq \mathrm{V}_{\mathrm{CB}} \leq \mathrm{V}_{\text {MAX }}$ | - | 30 | 70 | - | 30 | 70 | pA/V |
| Bulk Resistance | $\mathrm{r}_{\text {BE }}$ | $10 \mu \mathrm{~A} \leq \mathrm{I}_{\mathrm{C}} \leq 10 \mathrm{~mA}$ (Note 3) | - | 0.3 | 0.5 | - | 0.3 | 0.5 | $\Omega$ |
| Collector-Base <br> Leakage Current | $I^{\text {cBo }}$ | $\mathrm{V}_{\mathrm{CB}}=\mathrm{V}_{\text {MAX }}$ | - | 25 | 200 | - | 25 | 400 | PA |
| Collector-Collector Leakage Current | Icc | $\mathrm{V}_{\text {CC }}=\mathrm{V}_{\text {MAX }}($ Notes 3, 5) | - | 35 | 200 | - | 35 | 400 | pA |
| Collector-Emitter Leakage Current | Ices | $\begin{aligned} & V_{C E}=V_{\text {MAX }}(\text { Notes } 3,5) \\ & V_{B E}=0 \end{aligned}$ | - | 35 | 200 | - | 35 | 400 | pA |
|  |  | $\begin{aligned} & I_{C}=1 \mathrm{~mA}, V_{C B}=0,(\text { Note } 4) \\ & f_{O}=10 \mathrm{~Hz} \end{aligned}$ | - | 1.6 | 2 | - | 1.6 | 3 |  |
| Noise Voltage Density | $e_{n}$ | $\mathrm{f}_{\mathrm{O}}=100 \mathrm{~Hz}$ | - | 0.9 | 1 | - | 0.9 | 2 | $\mathrm{V} / \sqrt{\mathrm{Hz}}$ |
|  |  | $\mathrm{f}_{\mathrm{O}}=1 \mathrm{kHz}$ | - | 0.85 | 1 | - | 0.85 | 2 |  |
| " |  | $\mathrm{f}_{\mathrm{O}}=10 \mathrm{kHz}$ | - | 0.85 | 1 | - | 0.85 | 2 |  |
| Collector Saturation Voltage | $V_{\text {CE (SAT) }}$ | $\begin{aligned} & I_{C}=1 \mathrm{~mA} \\ & I_{B}=100 \mu A \end{aligned}$ | - | 0.05 | 0.1 | - | 0.05 | 0.2 | V |
| Input Bias Current | $I_{B}$ | $I_{C}=10 \mu \mathrm{~A}$ | - | - | 25 | - | - | 34 | $n \mathrm{~A}$ |
| Input Offset Current | los | $\mathrm{I}_{\mathrm{C}}=10 \mu \mathrm{~A}$ | - | - | 0.6 | - | - | 1.3 | nA |
| Breakdown Voltage | $B V_{C E O}$ | . | 40 | - | - | 40 | - | - | V |
| Gain-Bandwidth Product | $f_{T}$ | $I_{C}=10 \mathrm{~mA}, V_{C E}=10 \mathrm{~V}$ | - | 200 | - | - | 200 | - | MHz |
| Output Capacitance | $\mathrm{COB}_{\mathrm{OB}}$ | $V_{C B}=15 \mathrm{~V}, \mathrm{I}_{\mathrm{E}}=0$ | - | 23 | - | - | 23. | - | pF |
| Collector-Collector Capacitance | $\mathrm{C}_{\text {cc }}$ | $V_{c c}=0$ | - | 35 | - | - | 35 | - | pF |

## NOTES:

1. Current gain is guaranteed with Collector-Base Voltage ( $\mathrm{V}_{\mathrm{CB}}$ ) swept from 0 to $\mathrm{V}_{\mathrm{MAX}}$ at the indicated collector currents.
2. Current Gain Match $\left(\Delta h_{F E}\right)$ is defined as:

$$
\Delta h_{F E}=\frac{100\left(\Delta I_{\mathrm{B}}\right)\left(\mathrm{h}_{\mathrm{FE}} \min \right)}{I_{C}}
$$

3. Guaranteed by design.
4. Sample tested.
5. $I_{C C}$ and $I_{C E S}$ are verified by measurement of $I_{C B O}$.
6. This is the maximum change in $\mathrm{V}_{\mathrm{OS}}$ as $\mathrm{V}_{\mathrm{CB}}$ is swept from $O \mathrm{~V}$ to 40 V .
7. Measured at $\mathrm{I}_{\mathrm{C}}=10 \mu \mathrm{~A}$ and guaranteed by design over the specified range of $\mathrm{I}_{\mathrm{C}}$.

ELECTRICAL CHARACTERISTICS $V_{C B}=15 \mathrm{~V},-25^{\circ} \mathrm{C} \leq T_{A} \leq+85^{\circ} \mathrm{C}$, unless otherwise noted.


ELECTRICAL CHARACTERISTICS $V_{C B}=15 \mathrm{~V},-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$, unless otherwise noted.

|  |  |  | MAT-02A |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| PARAMETER |  |  |  |

## NOTES:

1. Guaranteed by $V_{O S}$ test $\left(T C V_{O S}=\frac{V_{O S}}{T}\right.$ for $\left.V_{O S} \ll V_{B E}\right) T=298 \mathrm{k}$ for $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
2. Current gain is guaranteed with Collector-Base Voltage ( $\mathrm{V}_{\mathrm{CB}}$ ) swept from 0 to $\mathrm{V}_{\text {MAX }}$ at the indicated collector current.
3. The initial zero offset voltage is established by adjusting the ratio of $I_{C 1}$ to $I_{C 2}$ at $T_{A}=25^{\circ} \mathrm{C}$. This ratio must be held to $0.003 \%$ over the entire temperature range. Measurements are taken at the temperature extremes and $25^{\circ} \mathrm{C}$.
4. Guaranteed by design.
5. Measured at $I_{C}=10 \mu A$ and guaranteed by design over the specified range of $I_{C}$.

## FEATURES

- Dual Matched PNP Transistor
- Low Offset Voltage $\qquad$ $100 \mu \mathrm{~V}$ Max
- Low Noise $\qquad$ @ 1kHz Max
- High Gain $1 n \mathrm{~V} / \sqrt{\mathrm{Hz}}$ @ 1 100 Min
- High Gain Bandwidth . . . . . . . . . . . . . . . . . . . . . . 190 MHz Typ
- Tight Gain Matching . . . . . . . . . . . . . . . . . . . . . . . . . . . 3\% Max
- Excellent Logarithmic Conformance. . . . . . . $\mathrm{r}_{\mathrm{BE}} \simeq 0.3 \Omega$ Typ
- Available in Die Form


## ORDERING INFORMATION $\dagger$

| $\begin{gathered} \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ \mathrm{~V}_{\text {OS }} \mathrm{MAX} \\ (\mu \mathrm{~V}) \end{gathered}$ | PACKAGE |  | OPERATING TEMPERATURE RANGE |
| :---: | :---: | :---: | :---: |
|  | T0-78 | LCC |  |
| 100 | MAT03AH* | MAT03ARC/883 | MIL |
| - 100 | MATO3EH | - | XIND |
| 200 | MAT03FH | - | XIND |

- For devices processed in total compliance to MIL-STD-883, add /883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on industrial temperature range parts.


## GENERAL DESCRIPTION

The MAT-03 dual monolithic PNP transistor offers excellent parametric matching and high frequency performance. Low noise characteristics ( $1 \mathrm{nV} / \sqrt{\mathrm{Hz}} \mathrm{Max} @ 1 \mathrm{kHz}$ ), high bandwidth ( 190 MHz typical), and low offset voltage ( $100 \mu \mathrm{~V}$ Max), makes the MAT-03 an excellent choice for demanding preamplifier applications. Tight current gain matching ( $3 \%$ Max mismatch) and high current gain ( 100 Min ), over a wide range of collector current, makes the MAT-03 an excellent choice for current mirrors. A low value of bulk resistance (typically $0.3 \Omega$ ) also makes the MAT-03 an ideal component for applications requiring accurate logarithmic conformance.

Each transistor is individually tested to data sheet specifications. Device performance is guaranteed at $25^{\circ} \mathrm{C}$ and over the extended industrial and military temperature ranges. To insure the long-term stability of the matching parameters, internal protection diodes across the base-emitter junction clamp any reverse base-emitter junction potential. This prevents a baseemitter breakdown condition which can result in degradation of gain and matching performance due to excessive breakdown current.

PIN CONNECTIONS


This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.
ABSOLUTE MAXIMUM RATINGS (Note 1)
Collector-Base Voltage ( $\mathrm{BV}_{\mathrm{CBO}}$ ) ..... 36 V
Collector-Emitter Voltage ( $\mathrm{BV}_{\mathrm{CEO}}$ ) ..... 36V
Collector-Collector Voltage ( $\mathrm{BV}_{\mathrm{CC}}$ ) ..... 36V
Emitter-Emitter Voltage (BV $\mathrm{EE}^{\text {) }}$ ..... 36V
Collector Current ( $I_{C}$ ) ..... 20 mA
Emitter Current ( $\mathrm{I}_{\mathrm{E}}$ ) ..... 20 mA
Total Power Dissipation
Ambient Temperature $\leq 70^{\circ} \mathrm{C}$ (Note 2) ..... 500 mW
Operating Temperature Range
MAT-03A
MAT-03A

$$
-55^{\circ} \mathrm{C} \text { to }+125^{\circ} \mathrm{C}
$$

$$
\text { MAT-03E/F . . . . . . . . . . . . . . . . . . . . . . . . . . . . . }-40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C}
$$

Operating Junction Temperature .................. $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Storage Temperature .................................... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 60 sec ) ........................ $+300^{\circ} \mathrm{C}$
Junction Temperature .................................... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

## NOTES:

1. Absolute maximum ratings apply to both DICE and packaged devices
2. Rating applies to TO-78 not using a heat sink, and LCC; devices in free air only. For TO-78, derate linearly at $6.3 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $70^{\circ} \mathrm{C}$ ambient temperature; for LCC, derate at $7.8 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$.

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | MAT-03A |  |  | MAT-03E |  |  | MAT-03F |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX |  |  |  |  |
| Current Gain (Note 1) | $h_{\text {fe }}$ | $\mathrm{V}_{\mathrm{CB}}=0 \mathrm{~V},-36 \mathrm{~V}$ |  |  |  |  |  |  |  |  |  |  |
|  |  | $\mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}$ | 100 | 165 | - | 100 | 165 | - | 80 | 165 | - |  |
|  |  | $\mathrm{I}_{\mathrm{C}}=100 \mu \mathrm{~A}$ | 90 | 150 | - | 90 | 150 | - | 70 | 150 | - |  |
|  |  | $\mathrm{I}_{\mathrm{C}}=10 \mu \mathrm{~A}$ | 80 | 120 | - | 80 | 120 | - | 60 | 120 | - | . |
| Current Gain Matching (Note 2) | $\Delta h_{\text {FE }}$ | $\mathrm{I}_{\mathrm{C}}=100 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{CB}}=0 \mathrm{~V}$ | - | 0.5 | 3 | - | 0.5 | 3 | - | 0.5 | 6 | \% |
| Offset Voltage (Note 3) | $\mathrm{V}_{\text {OS }}$ | $V_{C B}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=100 \mu \mathrm{~A}$ | - | 40 | 100 | - | 40 | 100 | - | 40 | 200 | $\mu \mathrm{V}$ |
| Offset Voltage Change vs Collector Voltage | $\Delta \mathrm{V}_{\mathrm{OS}} / \Delta \mathrm{V}_{\mathrm{CB}}$ | $\begin{gathered} \mathrm{I} \mathrm{C}=100 \mu \mathrm{~A} \\ \mathrm{~V}_{\mathrm{CB}_{1}}=0 \mathrm{~V} \\ \mathrm{~V}_{\mathrm{CB}_{2}}=-36 \mathrm{~V} \end{gathered}$ | - | 11 | 150 | - | 11 | 150 | - | 11 | 200 | $\mu \mathrm{V}$ |
| Offset Voltage Change vs Collector Current | $\Delta \mathrm{V}_{\mathrm{OS}} / \Delta \mathrm{l}_{\mathrm{C}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{CB}}=0 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{C}_{1}}=10 \mu \mathrm{~A}, \mathrm{I}_{\mathrm{C}_{2}}=1 \mathrm{~mA} \end{aligned}$ | - | 12 | 50 | - | 12 | 50 | - | 12 | 75 | $\mu \mathrm{V}$ |
| Bulk Resistance | $r_{B E}$ | $\begin{aligned} & V_{C B}=0 V \\ & 10 \mu \mathrm{~A} \leq \mathrm{I}_{\mathrm{C}} \leq 1 \mathrm{~mA} \end{aligned}$ | - | 0.3 | 0.75 | - | 0.3 | 0.75 | - | 0.3 | 0.75 | $\Omega$ |
| Offset Current | l OS | $\mathrm{I}_{\mathrm{C}}=100 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{CB}}=0 \mathrm{~V}$ | - | 6 | 35 | - | 6 | 35 | - | 6 | 45 | nA |
| Collector-Base <br> Leakage Current | ${ }^{\prime} \mathrm{CB}_{0}$ | $V_{C B}=-36 \mathrm{~V}=\mathrm{V}_{\text {MAX }}$ | - | 50 | 200 | - | 50 | 200 | - | 50 | 400 | pA |
| Noise Voltage Density (Note 4) | $e_{N}$ | $\mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}, \mathrm{~V}_{C B}=0$ |  |  |  |  |  |  |  |  |  |  |
|  |  | $f 0=10 \mathrm{~Hz}$ | - | 0.8 | 2 | - | 0.8 | - | - | 0.8 | - |  |
|  |  | $f 0=100 \mathrm{~Hz}$ | - | 0.7 | 1 | - | 0.7 | - | - | 0.7 | - | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
|  |  | $f \mathrm{O}=1 \mathrm{kHz}$ | - | 0.7 | 1 | - | 0.7 | - | - | 0.7 | - | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
|  |  | $f \mathrm{o}=10 \mathrm{kHz}$ | - | 0.7 | 1 | - | 0.7 | - | - | 0.7 | - |  |
| Collector Saturation Voltage | $V_{\text {CE(SAT }}$ | $\mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=100 \mu \mathrm{~A}$ | - | 0.025 | 0.1 | - | 0.025 | 0.1 | - | 0.025 | 0.1 | V |

## NOTES:

1. Current gain is measured at collector-base voltages ( $\mathrm{V}_{\mathrm{CB}}$ ) swept from 0 to
$\mathrm{V}_{\text {MAX }}$ at indicated collector current. Typicals are measured at $\mathrm{V}_{\mathrm{CB}}=0 \mathrm{~V}$
2. Current gain matching ( $\Delta \mathrm{h}_{\mathrm{FE}}$ ) is defined as:
$\Delta h_{F E}=\frac{100\left(\Delta I_{B}\right) h_{F E}(\text { MIN })}{I_{C}}$
3. Offset voltage is defined as:
$V_{O S}=V_{B E_{1}}-V_{B_{E_{2}}}$,
where $V_{O S}$ is the differential voltage for
$I_{C_{1}}=I_{C_{2}}: V_{O S}=V_{B_{1}}-V_{B_{2}}=\frac{K T}{q} \ln \left(\frac{I_{C_{1}}}{I_{C_{2}}}\right)$.
4. Sample tested. Noise tested and specified as equivalent input voltage for each transistor.

ELECTRICAL CHARACTERISTICS at $-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+125^{\circ} \mathrm{C}$, unless otherwise noted.


NOTE:

1. Guaranteed by $V_{O S}$ test $\left(T C V_{O S}=V_{O S} / T\right.$ for $\left.V_{O S} \ll V_{B E}\right)$ where $T=298^{\circ} \mathrm{K}$ for $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.

ELECTRICAL CHARACTERISTICS at $-40^{\circ} \mathrm{C} \leq T_{A} \leq+85^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | MAT-03E |  |  | MAT-03F |  | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP |  |  |
| Current Gain | $\mathrm{h}_{\text {FE }}$ | $\mathrm{V}_{C B}=0 \mathrm{~V},-36 \mathrm{~V}$ |  |  |  |  |  |  |  |
|  |  | $\mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}$ | 70 | 120 | - | 60 | 120 | - |  |
|  |  | $\mathrm{I}_{\mathrm{C}}=100 \mu \mathrm{~A}$ | 60 | 105 | - | 50 | 105 | - |  |
|  |  | $\mathrm{I}_{\mathrm{C}}=10 \mu \mathrm{~A}$ | 50 | 90 | - | 40 | 90 | - |  |
| Offset Voltage | $\mathrm{V}_{\text {OS }}$ | $\mathrm{I}_{\mathrm{C}}=100 \mu \mathrm{~A}, \mathrm{~V}_{C B}=0 \mathrm{~V}$ | - | 30 | 135 | - | 30 | 265 | $\mu \mathrm{V}$ |
| Offset Voltage Drift (Note 1) | $\mathrm{TCV}_{\text {OS }}$ | $\mathrm{I}_{\mathrm{C}}=100 \mu \mathrm{~A}, \mathrm{~V}_{C B}=0 \mathrm{~V}$ | - | 0.3 | 0.5 | - | 0.3 | 1.0 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Offset Current | los | $\mathrm{I}_{\mathrm{C}}=100 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{CB}}=0 \mathrm{~V}$ | - | 10 | 85 | - | 10 | 200 | $n A$ |
| Breakdown Voltage | $B V_{\text {CEO }}$ |  | 36 | -. | - | 36 | - | - | V |

## NOTE:

1: Guaranteed by $V_{O S}$ test $\left(T C V_{O S}=V_{O S} / T\right.$ for $\left.V_{O S} \ll V_{B E}\right)$ where $T=298^{\circ} \mathrm{K}$ for $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.

ANALOG
Matched Monolithic
DEVICES

FEATURES

- Low Offset Voltage 200 H V Max
- High Current Gain 400 Min
- Excellent Current Gain Match .............................. 2\% Max
- Low Noise Voltage at 100 Hz , 1 mA .......... $2.5 \mathrm{nV} / \mathrm{Hz}$ Max
- Excellent Log Conformance ................... rBE $=0.6 \Omega$ Max
- Matching Guaranteed for All Transistors
- Available in Die Form


## ORDERING INFORMATION ${ }^{\dagger}$

| $\begin{gathered} \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ \mathrm{~V}_{\mathrm{OS}}^{\mathrm{MAXX}} \\ (\mu \mathrm{~V}) \end{gathered}$ | PACKAGE |  | OPERATING TEMPERATURE RANGE |
| :---: | :---: | :---: | :---: |
|  | CERDIP <br> 14-PIN | PLASTIC <br> 14-PIN |  |
| 200 | MAT04AY* | - | MIL |
| 200 | MAT04EY | - | IND |
| 400 | MAT04BY* | - | MIL |
| 400 | MAT04FY | MAT04FP | XIND |
| 400 | - | MAT04FS ${ }^{\text {+ }}$ | XIND |

* For devices processed in total compliance to MIL-STD-883, add/883 after part number. Consult factory for 883 data sheet.
$\dagger$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.
tt For availability and burn-in information on SO and PLCC packages, contact your local sales office.


## GENERAL DESCRIPTION

The MAT-04 is a quad monolithic NPN transistor that offers excellent parametric matching for precision amplifier and nonlinear circuit applications. Performance characteristics of the MAT-04 include high gain ( 400 minimum) over a wide range of collector current, low noise $(2.5 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ maximum at 100 Hz , $\mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}$ ) and excellent logarithmic conformance. The MAT-04 also features a low offset voltage of $200 \mu \mathrm{~V}$ and tight current gain matching, to within $2 \%$. Each transistor of the MAT-04 is individually tested to data sheet specifications. For matching parameters (offset voltage, input offset current, and gain match), each of the dual transistor combinations are verified to meet stated limits. Device performance is guaranteed at $25^{\circ} \mathrm{C}$ and over the industrial and military temperature ranges.
The long-term stability of matching parameters is guaranteed by the protection diodes across the base-emitter junction of each transistor. These diodes prevent degradation of beta and matching characteristics due to reverse bias base-emitter current.
The superior logarithmic conformance and accurate matching characteristics of the MAT-04 makes it an excellent choice for use in log and antilog circuits. The MAT-04 is an ideal choice in applications where low noise and high gain are required.

PIN CONNECTIONS

ABSOLUTE MAXIMUM RATINGS (Note 1)
Collector-Base Voltage ( $\mathrm{BV}_{\mathrm{cBO}}$ ) ..... 40V
Collector-Emitter Voltage ( $\mathrm{BV}_{\mathrm{CEO}}$ ) ..... 40 V
Collector-Collector Voltage ( $\mathrm{BV}_{\mathrm{CC}}$ ) ..... 40V
Emitter-Emitter Voltage ( $\mathrm{BV}_{\mathrm{EE}}$ ) ..... 40V
Collector Current ..... 30 mA
Emitter Current ..... 30 mA
Substrate (Pin-4 to Pin-11) Current ..... 30 mA
Operating Temperature Range
MAT-04AY, BY
MAT-04AY, BY $-55^{\circ} \mathrm{C}$ TO $+125^{\circ} \mathrm{C}$ $-55^{\circ} \mathrm{C}$ TO $+125^{\circ} \mathrm{C}$
MAT-04EY $-25^{\circ} \mathrm{C}$ TO $+85^{\circ} \mathrm{C}$
MAT-04FY,FP,FS $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature
Y Package ................................................. $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
P Package $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 60 sec ) ..... $+300^{\circ} \mathrm{C}$

| PACKAGE TYPE | $\Theta_{\mathrm{jA}}$ (Note 2) | $\Theta_{\mathrm{jC}}$ | UNITS |
| :--- | :---: | :---: | :---: |
| 14-Pin CERDIP (Y) | 108 | 16 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 14-Pin Plastic DIP (P) | 83 | 39 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 14-Pin SO $(\mathrm{S})$ | 120 | 36 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

NOTES:

1. Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.
2. $\Theta_{i A}$ is specified for worst case mounting conditions, i.e., $\Theta_{j A}$ is specified for device in socket for CerDIP and P-DIP packages; $\Theta_{j A}$ is specified for device soldered to printed circuit board for SO package.
[^215]ELECTRICAL CHARACTERISTICS at $T_{A}=25^{\circ} \mathrm{C}$ unless otherwise noted. Each transistor is individually tested. For matching parameters ( $\mathrm{V}_{\mathrm{OS}}, \mathrm{l}_{\mathrm{OS}}, \Delta \mathrm{h}_{\mathrm{FE}}$ ) each dual transistor combination is verified to meet stated limits. All tests made at endpoints unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | MAT-04A/E |  |  | MAT-04B/F |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Current Gain | $h_{\text {FE }}$ | $\begin{aligned} & 10 \mu \mathrm{~A} \leq \mathrm{I}_{\mathrm{C}} \leq 1 \mathrm{~mA} \\ & 0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{B}} \leq 30 \mathrm{~V} \\ & \text { (Note 1) } \end{aligned}$ | 400 | 800 | - | 300 | 600 | - |  |
| Current Gain Match | $\Delta h_{\text {FE }}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{C}}=100 \mu \mathrm{~A} \\ & 0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CB}} \leq 30 \mathrm{~V} \\ & \text { (Note 2). } \end{aligned}$ | - | 0.5 | 2 | - | 1 | 4 | \% \% |
| Offset Voltage | $\mathrm{V}_{\text {os }}$ | $\begin{aligned} & 10 \mu \mathrm{~A} \leq \mathrm{I}_{\mathrm{C}} \leq 1 \mathrm{~mA} \\ & 0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CB}} \leq 30 \mathrm{~V} \\ & \text { (Note 4) } \end{aligned}$ | - | 50 | 200 | - | 100 | 400 | $\mu \mathrm{V}$ |
| Offset Voltage Changevs Collector Current | $\Delta \mathrm{V}_{\text {S }} / \Delta \mathrm{l}_{\mathrm{C}}$ | $\begin{aligned} & 10 \mu \mathrm{~A} \leq I_{\mathrm{C}} \leq 1 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{CB}}=0 \mathrm{~V} \\ & \text { (Note } 4 \text { ) } \end{aligned}$ | - | 5 | 25 | - | 10 | 50 | $\mu \mathrm{V}$ |
| Offset Voltage Change vs $\mathrm{V}_{\mathrm{CB}}$ | $\Delta V_{O S} / \Delta V_{\text {CB }}$ | $\begin{aligned} & 10 \mu \mathrm{~A} \leq \mathrm{I}_{\mathrm{C}} \leq 1 \mathrm{~mA} \\ & 0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CB}} \leq 30 \mathrm{~V} \\ & \text { (Note 4) } \end{aligned}$ | - | 50 | 100 | - | 100 | 200 | $\mu \mathrm{V}$ |
| Bulk Emitter Resistance | ${ }^{\text {r }}$ BE | $\begin{aligned} & 10 \mu \mathrm{~A} \leq \mathrm{I}_{\mathrm{C}} \leq 1 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{CB}}=0 \mathrm{~V} \\ & \text { (Note } 5 \text { ) } \end{aligned}$ | - | 0.4 | 0.6 | - | 0.4 | 0.6 | $\Omega$ |
| Input Bias Current | $I_{B}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{C}}=100 \mu \mathrm{~A} \\ & \mathrm{OV} \leq \mathrm{V}_{\mathrm{CB}} \leq 30 \mathrm{~V} \end{aligned}$ | - | 125 | 250 | - | 165 | 330 | nA |
| Input Offset Current | los | $\begin{aligned} & I_{C}=100 \mu A^{\prime} \\ & V_{C B}=0 \mathrm{~V} \end{aligned}$ | - | 0.6 | 5 | - | 2 | 13 | nA |
| Breakdown Voltage | BVCEO | $\mathrm{I}_{\mathrm{C}}=10 \mu \mathrm{~A}$ | 40 | - | - | 40 | - | - | V |
| Collector Saturation Voltage | $\mathrm{V}_{\text {CEISAT }}$ | $\begin{aligned} & I_{B}=100 \mu \mathrm{~A} \\ & I_{C}=1 \mathrm{~mA} \end{aligned}$ | - | 0.03 | 0.06 | - | 0.03 | 0.06 | V |
| Collector-Base Leakage Current | $\mathrm{I}_{\text {cbo }}$ | $\mathrm{V}_{\mathrm{CB}}=40 \mathrm{~V}$ | - | 5 | - | - | 5 | - | pA |
| Noise Voltage Density | $e_{n}$ | $\begin{array}{ll} \mathrm{V}_{\mathrm{CB}}=0 \mathrm{~V} & \mathrm{f}_{\mathrm{O}}=10 \mathrm{~Hz} \\ \mathrm{I}_{\mathrm{c}}=1 \mathrm{~mA} & \mathrm{f}_{\mathrm{O}}=100 \mathrm{~Hz} \\ \text { (Note } 3 \text { ) } & \mathrm{f}_{\mathrm{O}}=1 \mathrm{kHz} \end{array}$ | - | $\begin{array}{r} 2 \\ 1.8 \\ 1.8 \\ \hline \end{array}$ | $\begin{array}{r} 3 \\ 2.5 \\ 2.5 \end{array}$ | - | $\begin{array}{r} 2 \\ 1.8 \\ 1.8 \\ \hline \end{array}$ | $\begin{aligned} & 4 \\ & 3 \\ & 3 \end{aligned}$ | $n \mathrm{~V} / \sqrt{\mathrm{Hz}}$ |
| $\begin{aligned} & \text { Gain Bandwidth } \\ & \text { Product } \end{aligned}$ | ${ }_{\text {f }}$ | $\begin{aligned} & I_{C}=1 \mathrm{~mA} \\ & V_{C E}=10 \mathrm{~V} \end{aligned}$ | - | 300 | - | - | 300 | - | MHz |
| Output Capacitance | $\mathrm{C}_{\text {ово }}$ | $\begin{aligned} & V_{C B}=15 \mathrm{~V} \quad \quad_{\mathrm{E}}=0 \\ & f=1 \mathrm{MHz} \end{aligned}$ | - | 10 | - | - | 10 | - | pF |
| Input Capacitance | $\mathrm{C}_{\text {Ebo }}$ | $\begin{aligned} & V_{\mathrm{BE}}=\mathrm{OV} \quad \mathrm{I}_{\mathrm{C}}=0 \\ & \mathrm{f}=1 \mathrm{MHZ} \end{aligned}$ | - | 40 | - | - | 40 | - | pF |

## NOTES:

1. Current gain measured at $I_{C}=10 \mu A, 100 \mu A$ and $1 m A$.
2. Current gain match is defined as: $\Delta h_{F E}=\frac{100\left(\Delta I_{B}\right)\left(h_{F E} \min \right)}{I_{C}}$
3. Sample tested.
4. Measured at $\mathrm{I}_{\mathrm{C}}=10 \mu \mathrm{~A}$ and guaranteed by design over the specified range of I .
5. Guaranteed by design.

ELECTRICAL CHARACTERISTICS at $-25^{\circ} \mathrm{C} \leq T_{A} \leq+85^{\circ} \mathrm{C}$ for MAT- $04 \mathrm{E},-40^{\circ} \mathrm{C} \leq T_{A} \leq+85^{\circ} \mathrm{C}$ for MAT-04F, unless otherwise noted. Each transistor is individually tested. For matching parameters ( $V_{O S}, I_{O S}$ ) each dual transistor combination is verified to meet stated limits. All tests made at endpoints unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | MAT-04E |  |  | MAT-04F |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Current Gain | $h_{\text {FE }}$ | $\begin{aligned} & 10 \mu A \leq I_{C} \leq 1 \mathrm{~mA} \\ & 0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CB}} \leq 30 \mathrm{~V} \\ & \text { (Note 1) } \end{aligned}$ | 225 | 625 | - | 200 | 500 | - |  |
| Offset Voltage | $\mathrm{V}_{\text {OS }}$ | $\begin{aligned} & 10 \mu \mathrm{~A} \leq \mathrm{I}_{\mathrm{C}} \leq 1 \mathrm{~mA} \\ & 0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CB}} \leq 30 \mathrm{~V} \end{aligned}$ <br> (Note 3) | - | 60 | 260 | - | 120 | 520 | $\mu \mathrm{V}$ |
| Average Offset Voltage Drift | $\mathrm{TCV}_{\text {OS }}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{C}}=100 \mu \mathrm{~A} \\ & \mathrm{~V}_{\mathrm{CB}}=0 \mathrm{~V} \\ & \text { (Note 2) } \end{aligned}$ | - | 0.2 | 1 | - | 0.4 | 2 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Bias Current | $I_{B}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{C}}=100 \mu \mathrm{~A} \\ & \mathrm{OV} \leq \mathrm{V}_{\mathrm{CB}} \leq 30 \mathrm{~V} \end{aligned}$ | - | 160 | 445 | - | 200 | 500 | $n A$ |
| Input Offset Current | Ios | $\begin{aligned} & \mathrm{I}_{\mathrm{C}}=100 \mu \mathrm{~A} \\ & \mathrm{~V}_{\mathrm{CB}}=0 \mathrm{~V} \end{aligned}$ | - | 4 | 20 | - | 8 | 40 | nA |
| Average Offset Current Drift | $\mathrm{TCl}_{\mathrm{OS}}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{C}}=100 \mu \mathrm{~A} \\ & \mathrm{~V}_{\mathrm{CB}}=0 \mathrm{~V} \end{aligned}$ | - | 50 | - | - | 100 | - | $\mathrm{pA} /{ }^{\circ} \mathrm{C}$ |
| Breakdown Voltage | $\mathrm{BV}_{\text {CEO }}$ | $\mathrm{I}_{\mathrm{C}}=10 \mu \mathrm{~A}$ | 40 | - | - | 40 | - | - | V |
| Collector-Base Leakage Current | $\mathrm{I}_{\text {CBO }}$ | $V_{C B}=40 \mathrm{~V}$ | - | 0.5 | - | - | 0.5 | - | nA |
| Collector-Emitter Leakage Current | ${ }^{\text {cees }}$ | $V_{C E}=40 \mathrm{~V}$ | - | 5 | - | - | 5 | - | nA |
| Collector-Substrate Leakage Current | Ics | $\mathrm{V}_{\text {CS }}=40 \mathrm{~V}$ | - | 0.7 | - | - | 0.7 | - | nA |

ELECTRICAL CHARACTERISTICS at $-55^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq 125^{\circ} \mathrm{C}$ unless otherwise noted. Each transistor is individually tested. For matching parameters ( $\mathrm{V}_{\mathrm{OS}}, \mathrm{l}_{\mathrm{OS}}$ ) each dual transistor combination is verified to meet stated limits. All tests made at endpoints unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | MAT-04A |  |  | MAT-04B |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Current Gain | $\mathrm{hfe}^{\text {fe }}$ | $\begin{aligned} & 10 \mu A \leq I_{C} \leq 1 \mathrm{~mA} \\ & 0 V \leq V_{C B} \leq 30 \mathrm{~V} \\ & \text { (Note 1) } \end{aligned}$ | 175 | 475 | - | 125 | 425 | - |  |
| Offset Voltage | $\mathrm{V}_{\text {OS }}$ | $\begin{aligned} & 10 \mu A \leq I_{C} \leq 1 \mathrm{~mA} \\ & 0 V \leq V_{C B} \leq 30 V \end{aligned}$ <br> (Note 3) | - | 70 | 300 | - | 140 | 600 | $\mu \mathrm{V}$ |
| Average Offset Voltage Drift | $\mathrm{TCV}_{\text {OS }}$ | $\begin{aligned} & I_{C}=100 \mu \mathrm{~A} \\ & \mathrm{~V}_{\mathrm{CB}}=0 \mathrm{~V} \\ & \text { (Note 2) } \end{aligned}$ | - | 0.2 | 1 | - | 0.4 | 2 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Input Bias Current | $I_{B}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{C}}=100 \mu \mathrm{~A} \\ & \mathrm{OV} \leq \mathrm{V}_{\mathrm{CB}} \leq 30 \mathrm{~V} \end{aligned}$ | - | 210 | 570 | - | 235 | 800 | nA |
| Input Offset Current | los | $\begin{aligned} & \mathrm{I}_{\mathrm{C}}=100 \mu \mathrm{~A} \\ & \mathrm{~V}_{\mathrm{CB}}=0 \mathrm{~V} \end{aligned}$ | - | 6 | 30 | - | 12 | 60 | nA |
| Average Offset Current Drift | $\mathrm{TCl}_{\mathrm{OS}}$ | $\begin{aligned} & I_{C}=100 \mu \mathrm{~A} \\ & \mathrm{~V}_{\mathrm{CB}}=0 \mathrm{~V} \end{aligned}$ | - | 50 | - | - | 100 | - | $\mathrm{pA} /{ }^{\circ} \mathrm{C}$ |
| Breakdown Voltage | $B V_{\text {CEO }}$ | $\mathrm{I}_{\mathrm{C}}=10 \mu \mathrm{~A}$ | 40 | - | - | 40 | - | - | V |
| Collector-Base Leakage Current | $I_{\text {cbo }}$ | $V_{C B}=40 \mathrm{~V}$ | - | 5 | - | - | 5 | - | nA |
| Collector-Emitter Leakage Current | $\mathrm{I}_{\text {ces }}$ | $V_{C E}=40 \mathrm{~V}$ | - | 100 | - | - | 100 | - | nA |
| Collector-Substrate Leakage Current | $\mathrm{I}_{\mathrm{CS}}$ | $V_{C S}=40 \mathrm{~V}$ | - | 7 | - | - | 7 | - | nA |
| NOTES: <br> 1. Current gain mea <br> 2. Guaranteed by | $\begin{aligned} & =10 \mu \mathrm{~A}, 100 \mu \\ & \mathrm{~V}_{\mathrm{OS}} \leqslant \mathrm{~V}_{\mathrm{OS}} / \end{aligned}$ | $\left.V_{B E}\right) T=298^{\circ} K$ | Mea of I | sured | $I_{C}=10$ | rante | by de | n ove | d range | $T_{A}=25^{\circ} \mathrm{C}$.

## Audio Components Contents

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Selection Tree - Audio Components


## Selection Guides-Audio Components

Amplifiers

| Model | Function | $\begin{aligned} & \text { en nV } / \sqrt{\mathrm{Hz}} \\ & 20 \mathrm{kHz} \mathrm{BW} \end{aligned}$ | THD +N <br> @ $1 \mathbf{k H z}$ | $\begin{aligned} & \text { BW } \\ & \text { MHz } \end{aligned}$ | Package Option ${ }^{1}$ | Temp Ranges ${ }^{2}$ | Comments | Page |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SSM2017 | Audio Preamplifier | 0.95 | 0.005\% | 4.0 | N, R | I | Low Noise, 8-Pin DIP, High Gain | 14-5 |
| SSM2135 | Dual Audio Op Amp | 5.2 | 0.001\% | 3.5 | N, R | I | +5 V Supply, 8-Pin DIP, High Output | 14-14 |
| SSM2141 | Differential Line Receiver | 22.0 | 0.001\% | 3 | N, R | I | High CMRR, Drives $600 \Omega$ | 14-24 |
| SSM2142 | Balanced Line Driver | 117.0 | 0.006\% | - | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I | 10 V RMS into $600 \Omega$, High Cap Load | 14-26 |
| SSM2143 | Differential Line Receiver | 23.6 | 0.0006\% | 7 | N, R | I | Gain $=1 / 2$ or 2, High CMRR | 14-28 |

## Volume Control/Voltage-Controlled Amplifiers



## SSM2017

## FEATURES

Excellent Noise Performance: $950 \mathrm{pV} / \sqrt{\overline{\mathrm{Hz}}}$ or 1.5 dB Noise Figure
Ultralow THD: $<\mathbf{0 . 0 1 \%}$ @ G = 100 Over the Full Audio Band
Wide Bandwidth: $1 \mathrm{MHz} @ \mathbf{G}=100$
High Slew Rate: 17 V/ $\mu \mathrm{s}$ typ
Unity Gain Stable
True Differential Inputs
Subaudio 1/f Noise Corner
8-Pin Mini-DIP with Only One External Component Required
Very Low Cost
Extended Temperature Range: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$

## APPLICATIONS

Audio Mix Consoles
Intercom/Paging Systems
Two-Way Radio
Sonar
Digital Audio Systems

## GENERAL DESCRIPTION

The SSM-2017 is a latest generation audio preamplifier combining SSM preamplifier design expertise with advanced processing. The result is excellent audio performance from a selfcontained 8 -pin mini-DIP device, requiring only one external gain set resistor or potentiometer. The SSM-2017 is further enhanced by its unity gain stability.
Key specifications include ultralow noise ( 1.5 dB noise figure) and THD $(<0.01 \%$ at $G=100)$, complemented by wide bandwidth and high slew rate.
Applications for this low cost device include microphone preamplifiers and bus summing amplifiers in professional and consumer audio equipment, sonar, and other applications requiring a low noise instrumentation amplifier with high gain capability.

FUNCTIONAL BLOCK DIAGRAM


PIN CONNECTIONS
Epoxy Mini-DIP (P Suffix)


16-Pin Wide Body SOL (S Suffix)


This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

Typical specifications apply at $T_{A}=+25^{\circ} \mathrm{C}$.)

| Parameter | Symbol | Conditions | Min | Typ | ax | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DISTORTION PERFORMANCE Total Harmonic Distortion Plus Noise | THD +N | $\begin{aligned} & \hline \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{O}}=7 \mathrm{~V}_{\mathrm{RMS}} \\ & \mathrm{R}_{\mathrm{L}}=5 \mathrm{k} \Omega \\ & \mathrm{G}=1000, \mathrm{f}=1 \mathrm{kHz} \\ & \mathrm{G}=100, \mathrm{f}=1 \mathrm{kHz} \\ & \mathrm{G}=10, \mathrm{f}=1 \mathrm{kHz} \\ & \mathrm{G}=1, \mathrm{f}=1 \mathrm{kHz} \end{aligned}$ |  | $\begin{aligned} & 0.012 \\ & 0.005 \\ & 0.004 \\ & 0.008 \end{aligned}$ |  | $\begin{aligned} & \% \\ & \% \\ & \% \\ & \% \end{aligned}$ |
| NOISE PERFORMANCE Input Referred Voltage Noise Density Input Current Noise Density | ${ }^{\mathrm{e}_{\mathrm{n}}}$ | $\begin{aligned} & \mathrm{f}=1 \mathrm{kHz}, \mathrm{G}=1000 \\ & \mathrm{f}=1 \mathrm{kHz} ; \mathrm{G}=100 \\ & \mathrm{f}=1 \mathrm{kHz} ; \mathrm{G}=10 \\ & \mathrm{f}=1 \mathrm{kHz} ; \mathrm{G}=1 \\ & \mathrm{f}=1 \mathrm{kHz} ; \mathrm{G}=1000 \end{aligned}$ |  | $\begin{aligned} & 0.95 \\ & 1.95 \\ & 11.83 \\ & 107.14 \\ & 2 \end{aligned}$ |  | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ $\mathrm{pA} / \sqrt{\mathrm{H} \mathrm{z}}$ |
| DYNAMIC RESPONSE Slew Rate Small Signal Bandwidth | SR | $\begin{aligned} & \mathrm{G}=10 \\ & \mathrm{R}_{\mathrm{L}}=4.7 \mathrm{k} \Omega \\ & \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF} \\ & \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \mathrm{G}=1000 \\ & \mathrm{G}=100 \\ & \mathrm{G}=10 \\ & \mathrm{G}=1 \end{aligned}$ |  | 17 <br> 200 <br> 1000 <br> 2000 <br> 4000 |  | V/us <br> kHz <br> kHz <br> kHz <br> kHz |
| INPUT <br> Input Offset Voltage Input Bias Current Input Offset Current Common-Mode Rejection <br> Power Supply Rejection <br> Input Voltage Range Input Resistance | $\begin{array}{\|l} \mathrm{V}_{\mathrm{IOS}} \\ \mathrm{I}_{\mathrm{B}} \\ \mathrm{I}_{\mathrm{OS}} \\ \mathrm{CMR} \\ \\ \\ \\ \mathrm{PSR} \\ \\ \\ \\ \mathrm{IVR} \\ \mathrm{R}_{\mathrm{IN}} \end{array}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CM}}= \pm 8 \mathrm{~V} \\ & \mathrm{G}=1000 \\ & \mathrm{G}=100 \\ & \mathrm{G}=10 \\ & \mathrm{G}=1, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \mathrm{G}=1, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 6 \mathrm{~V} \text { to } \pm 18 \mathrm{~V} \\ & \mathrm{G}=1000 \\ & \mathrm{G}=100 \\ & \mathrm{G}=10 \\ & \mathrm{G}=1 \\ & \text { Differential, } \mathrm{G}=1000 \\ & \mathrm{G}=1 \\ & \text { Common Mode, } \mathrm{G}=1000 \\ & \mathrm{G}=1 \end{aligned}$ | $\begin{aligned} & 80 \\ & 60 \\ & 40 \\ & 26 \\ & 20 \\ & 80 \\ & 60 \\ & 40 \\ & 26 \\ & \pm 8 \end{aligned}$ | $\begin{aligned} & 0.1 \\ & 6 \\ & \pm 0.002 \\ & 112 \\ & 92 \\ & 74 \\ & 54 \\ & 54 \\ & \\ & 124 \\ & 118 \\ & 101 \\ & 82 \\ & \\ & 1 \\ & 30 \\ & 5.3 \\ & 7.1 \end{aligned}$ | $\begin{aligned} & 1.2 \\ & 25 \\ & \pm 2.5 \end{aligned}$ | mV <br> $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ <br> dB <br> dB <br> dB <br> dB <br> dB <br> dB <br> dB <br> dB <br> dB <br> V <br> M $\Omega$ <br> $\mathrm{M} \Omega$ <br> $\mathrm{M} \Omega$ $\mathrm{M} \Omega$ <br> $\mathrm{M} \Omega$ |
| OUTPUT <br> Output Voltage Swing Output Offset Voltage Minimum Resistive Load Drive <br> Maximum Capacitive Load Drive Short Circuit Current Limit Output Short Circuit Duration | $\begin{aligned} & \mathrm{v}_{\mathrm{o}} \\ & \mathrm{v}_{\mathrm{oos}} \\ & \\ & \mathrm{I}_{\mathrm{sc}} \end{aligned}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega ; \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \\ & \text { Output-to-Ground Short } \end{aligned}$ | $\pm 11.0$ | $\begin{aligned} & \pm 12.3 \\ & -40 \\ & 2 \\ & 4.7 \\ & 50 \\ & \pm 50 \end{aligned}$ | 500 10 | $\begin{aligned} & \mathrm{V} \\ & \mathrm{mV} \\ & \mathrm{k} \Omega \\ & \mathrm{k} \Omega \\ & \mathrm{pF} \\ & \mathrm{~mA} \\ & \mathrm{mec} \\ & \mathrm{sec} \end{aligned}$ |
| $\overline{\text { GAIN }}$ Gain Accuracy <br> Maximum Gain | $\begin{aligned} & R_{G}=\frac{10 k \Omega}{G-1} \\ & G \end{aligned}$ | $\begin{aligned} & \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \mathrm{R}_{\mathrm{G}}=10 \Omega, \mathrm{G}=1000 \\ & \mathrm{R}_{\mathrm{G}}=101 \Omega, \mathrm{G}=100 \\ & \mathrm{R}_{\mathrm{G}}=1.1 \mathrm{k} \Omega, \mathrm{G}=10 \\ & \mathrm{R}_{\mathrm{G}}=\infty, \mathrm{G}=1 \end{aligned}$ |  | $\begin{aligned} & 0.25 \\ & 0.20 \\ & 0.20 \\ & 0.05 \\ & 70 \\ & \hline \end{aligned}$ | $\begin{aligned} & 1 \\ & 1 \\ & 1 \\ & 0.5 \end{aligned}$ | $\begin{array}{\|l} \hline \mathrm{dB} \\ \mathrm{~dB} \\ \mathrm{~dB} \\ \mathrm{~dB} \\ \mathrm{~dB} \end{array}$ |


| Parameter | Symbol | Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| REFERENCE INPUT <br> Input Resistance Voltage Range Gain to Output |  | $\cdots$. |  | $\begin{aligned} & 10 \\ & \pm 8 \\ & 1 \end{aligned}$ |  | $\begin{aligned} & \mathrm{k} \Omega \\ & \mathrm{~V} \\ & \mathrm{~V} / \mathrm{V} \end{aligned}$ |
| POWER SUPPLY Supply Voltage Range Supply Current | $\begin{aligned} & \mathrm{V}_{\mathrm{S}} \\ & \mathrm{I}_{\mathrm{SX}} \end{aligned}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=\infty$ | $\pm 6$ | $\pm 10.6$ | $\begin{aligned} & \pm 22 \\ & \pm 14.0 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~mA} \end{aligned}$ |

Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS

Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 22$ V
Input Voltage . . . . . . . . . . . . . . . . . . . . . Supply Voltage
Output Short Circuit Duration . . . . . . . . . . . . . . . . . 10 sec
Storage Temperature Range ( $\mathrm{P}, \mathrm{Z}$ Packages). $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Junction Temperature ( $\mathrm{T}_{\mathrm{J}}$ ) . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature Range (Soldering, 60 sec ) . . . . . . . $300^{\circ} \mathrm{C}$
Operating Temperature Range . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Thermal Resistance ${ }^{1}$
8 -Pin Hermetic DIP $(\mathbf{Z}): \theta_{\mathrm{JA}}=134 ; \theta_{\mathrm{JC}}=12 \ldots \ldots{ }^{\circ} \mathrm{C} / \mathrm{W}$
8 -Pin Plastic DIP (P): $\theta_{\mathrm{JA}}=96 ; \theta_{\mathrm{JC}}=37 \ldots . . .{ }^{\circ} \mathrm{C} / \mathrm{W}$
$16-\operatorname{Pin} \operatorname{SOIC}(S): \theta_{\mathrm{JA}}=92 ; \theta_{\mathrm{JC}}=27 \ldots . . . . .{ }^{\circ} \mathrm{C} / \mathrm{W}$

NOTE
${ }^{1} \theta_{\mathrm{JA}}$ is specified for worst case mounting conditions, i.e., $\theta_{\mathrm{JA}}$ is specified for device in socket for cerdip and plastic DIP; $\theta_{\mathrm{JA}}$ is specified for device soldered to printed circuit board for SOL package.

## ORDERING GUIDE

| Model | Temperature <br> Range $^{\mathbf{1}}$ | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| SSM2017P | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | $\mathrm{N}-8$ <br> SSM2017S |
| $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 16-Lead SOL | $\mathrm{R}-16$ |  |

${ }^{1}$ XIND $=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.
${ }^{2}$ For outline information see Package Information section.

## Typical Performance Characteristics



Figure 1. Typical THD+Noise* at $G=1,10,100,1000$;
$V_{O}=7 V_{R M S}, V_{S}= \pm 15 \mathrm{~V}, R_{L}=5 \mathrm{k} \Omega ; T_{A}=+25^{\circ} \mathrm{C}$


Figure 2. Typical THD + Noise* at $G=2,10,100,1000$; $V_{O}=10 V_{R M S}, V_{S}= \pm 18 \mathrm{~V}, R_{L}=5 \mathrm{k} \Omega ; T_{A}=+25^{\circ} \mathrm{C}$
$\star 80 \mathrm{kHz}$ low-pass filter used for Figures 1-2.

$G=\frac{V_{\text {OUT }}}{(+I N)-(-I N)}=\left(\frac{10 k \Omega}{R_{G}}\right)+1$
Basic Circuit Connections

FEATURES

```
117 dB Dynamic Range 0.006\% Typical THD+N (@ 1 kHz, Unity Gain) 140 dB Gain Range No External Trimming Required Differential Inputs
Complementary Gain Outputs
Buffered Control Port
I-V Converter On-Chip (SSM2018T)
Differential Current Outputs (SSM2118T)
Low External Parts Count
Low Cost
```


## GENERAL DESCRIPTION

The SSM2018T and SSM2118T represent continuing evolution of the Frey Operational Voltage Element (OVCE) topology that permits flexibility in the design of high performance volume control systems. Voltage (SSM2018T) and differential current (SSM2118T) output versions are offered, both laser-trimmed for gain core symmetry and offset. As a result, the SSM2018T is the first professional audio quality VCA to offer trimless operation. The SSM2118T is ideal for low noise summing in large VCA based systems.
Due to careful gain core layout, the SSM2018T/SSM2118T combine the low noise of Class AB topologies with the low distortion of Class A circuits to offer an unprecedented level of sonic transparency. Additional features include differential inputs, a 140 dB gain range, and a high impedance control port. The SSM2018T provides an internal current-to-voltage converter; thus no external active components are required. The SSM 2118 T has fully differential current outputs that permit high noise-immunity summing of multiple channels.
Both devices are offered in 16-pin plastic DIP and SOIC packages and guaranteed for operation over the extended industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.
*Protected by U.S. Patent Nos. 4,471;320 and 4,560,947.

This is a preliminary data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

FUNCTIONAL BLOCK DIAGRAMS


This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

ELECTRICAL SPEC|F|CAT|ONS ${ }_{\left[V_{S}\right.}= \pm 15 \mathrm{~V}, \mathrm{~A}_{\mathrm{y}}=0 \mathrm{~dB}, \mathrm{R}_{\mathrm{L}}=100 \mathrm{k} \Omega, \mathrm{f}=1 \mathrm{kHz}, 0 \mathrm{dBu}=0.775 \mathrm{~V} \mathrm{rms}$, simple VCA application circuit with $18 \mathrm{k} \Omega$ resistors, $-V_{I N}$ floating, and Class AB gain core bias ( $R_{B}=150 \mathrm{k} \Omega$ ), $-40^{\circ} \mathrm{C}<\mathrm{T}_{A}<+85^{\circ} \mathrm{C}$, unless otherwise noted. Typical specifications apply at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.]

| Parameter | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| AUDIO PERFORMANCE ${ }^{1}$ <br> Noise <br> Headroom Total Harmonic Distortion plus Noise | $\mathrm{V}_{\mathrm{IN}}=\mathrm{GND}, 20 \mathrm{kHz} \text { Bandwidth }$ <br> Clip Point $=1 \% \mathrm{THD}+\mathrm{N}$ <br> 2nd and 3rd Harmonics Only ( $+25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ) $\begin{aligned} & \mathrm{A}_{\mathrm{V}}=0 \mathrm{~dB}, \mathrm{~V}_{\mathrm{IN}}=+10 \mathrm{dBu} \\ & \mathrm{~A}_{\mathrm{V}}=+20 \mathrm{~dB}, \mathrm{~V}_{\mathrm{IN}}=-10 \mathrm{dBu} \\ & \mathrm{~A}_{\mathrm{V}}=-20 \mathrm{~dB}, \mathrm{~V}_{\mathrm{IN}}=+10 \mathrm{dBu} \end{aligned}$ |  | $\begin{aligned} & -95 \\ & +22 \\ & \\ & 0.006 \\ & 0.013 \\ & 0.013 \end{aligned}$ | $\begin{aligned} & -93 \\ & \\ & 0.025 \\ & 0.014 \\ & 0.04 \end{aligned}$ | $\begin{aligned} & \mathrm{dBu} \\ & \mathrm{dBu} \\ & \% \\ & \% \\ & \% \end{aligned}$ |
| INPUT AMPLIFIER <br> Bias Current Offset Voltage Offset Current Input Impedance Common-Mode Range Gain Bandwidth <br> Slew Rate | $\begin{aligned} & \mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V} \end{aligned}$ <br> VCA Configuration VCP Configuration |  | $\begin{aligned} & 0.25 \\ & 1 \\ & 10 \\ & 4 \\ & \pm 13 \\ & 0.7 \\ & 14 \\ & 10 \end{aligned}$ | $\begin{aligned} & 1 \\ & 15 \\ & 100 \end{aligned}$ | $\mu \mathrm{A}$ <br> mV <br> nA <br> M $\Omega$ <br> V <br> MHz <br> MHz <br> V/ $\mu \mathrm{s}$ |
| OUTPUT AMPLIFIER (SSM2018T) <br> Offset Voltage <br> Output Voltage Swing <br> Minimum Load Resistance | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{C}}=+4 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{OUT}}=1.5 \mathrm{~mA} \\ & \text { Positive. } \end{aligned}$ <br> Negative <br> For Full Output Swing | $\begin{gathered} +10 \\ -10 \end{gathered}$ | $\begin{aligned} & 1.0 \\ & +13 \\ & +14 \\ & 9 \end{aligned}$ | 15 | $\begin{aligned} & \mathrm{mV} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{k} \Omega \end{aligned}$ |
| CONTROL PORT <br> Bias Current <br> Input Impedance <br> Gain Constant <br> Gain Constant Temperature Coefficient <br> Control Feedthrough <br> Maximum Attenuation | Device Powered in Socket $>60 \mathrm{sec}$ <br> +10 dB to -40 dB Gain Range $\mathrm{V}_{\mathrm{C}}=+4 \mathrm{~V}$ |  | $\begin{aligned} & 0.36 \\ & 1 \\ & -30 \\ & -3500 \\ & \pm 1 \\ & 100 \end{aligned}$ | 1 $\pm 4$ | $\mu \mathrm{A}$ <br> $\mathrm{M} \Omega$ <br> $\mathrm{mV} / \mathrm{dB}$ <br> $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ <br> mV <br> dB |
| POWER SUPPLIES <br> Supply Voltage Range <br> Supply Current Power Supply Rejection Ratio |  | $\pm 5$ | $\begin{aligned} & 11 \\ & 80 \end{aligned}$ | $\begin{aligned} & \pm 18 \\ & 15 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~mA} \\ & \mathrm{~dB} \end{aligned}$ |

${ }^{1}$ SSM2118T tested and characterized using OP275 as current-to-voltage converter.
Specifications subject to change without notice.

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

| ABSOLUTE MAXIMUM RATINGS ${ }^{1}$ |  |
| :---: | :---: |
| Supply Voltage |  |
| Dual Supply | $\pm 18 \mathrm{~V}$ |
| Input Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm$ V |  |
| Operating Temperature Range . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |
| Storage Temperature . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |  |
| Junction Temperature ( $\mathrm{T}_{\mathrm{J}}$ ) . . . . . . . . . . . . . . . . . . . $+150^{\circ} \mathrm{C}$ |  |
| Lead Temperature (Soldering, 60 sec ) . . . . . . . . . . $+300^{\circ} \mathrm{C}$ |  |
| THERMAL CHARACTERISTICS |  |
| Thermal Resistance ${ }^{2}$ |  |
| 16-Pin Plastic DIP |  |
| $\theta_{\text {JA }}$ | . $76^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\theta_{\mathrm{JC}}$ | $33^{\circ} \mathrm{C} / \mathrm{W}$ |
| 16-Pin SOIC |  |
| $\theta_{\text {JA }}$ | . $92^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\theta_{\text {JC }}$ | . $27^{\circ} \mathrm{C} / \mathrm{W}$ |

## TRANSISTOR COUNT

Number of Transistors
SSM2018T . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 125
SSM2118T .............................................. . . . 108

## ESD RATINGS

883 (Human Body) Model . . . . . . . . . . . . . . . . . . . . . . . 500 V
EIAJ Model . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 100 V
${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation section of this specification is not implied. Exposure to absolute maxi mum rating conditions for extended periods may affect device reliability.
${ }^{2} \theta_{\mathrm{JA}}$ is specified for worst-case conditions, i.e., $\theta_{\mathrm{JA}}$ is specified for device in socket for P-DIP and device soldered in circuit board for SOIC package.

## PIN CONFIGURATIONS



ORDERING GUIDE

| Model | Temperature Range | Package Option» |
| :--- | :--- | :--- |
| SSM2018TN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| SSM2018TR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16$ |
| SSM2118TN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| SSM2118TR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16$ |

* $\mathrm{N}=$ Plastic DIP; $\mathrm{R}=$ SOL. For outline information see Package Information section.


Figure 1. SSM2018T Detailed Functional Block Diagram

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the SSM2018T/SSM2118T features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.


Figure 5. SSM2118T Typical Application Circuit


Figure 4. SSM2118T Detailed Functional Diagram
This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

## FEATURES

- Four VCAs in One Package
- Ground Referenced Current Control Inputs
- 82dB S/N at 0.3 \% THD
- Full Class A Operation
- -40dB Control Feedthrough (Untrimmed)
- Easy Signal Summing
- 6\% Gain Matching


## APPLICATIONS

- Electronic Musical Instruments
- Noise Gating
- Compressor/Limiters
- Signal Mixing
- Automatic Gain Control
- Voltage-Controlled Oscillators


## ORDERING INFORMATION

| PACKAGE | OPERATING <br> PLEMPERATURE <br> RANGE <br> 16-PIN |
| :---: | :---: |
| SSM2024P | $-10^{\circ} \mathrm{C}$ to $+50^{\circ} \mathrm{C}$ |

## GENERAL DESCRIPTION

The SSM-2024 is a quad Class A noninverting current-controlled transconductance amplifier. Each of the four VCAs is completely independent and includes a ground referenced linear current gain control. These voltage-in/current-out amplifiers offer over 82dB $\mathrm{S} / \mathrm{N}$ at $0.3 \%$ THD. Other features include low control voltage feedthrough and minimal external components for most applications. With four matched VCAs in a single IC, the SSM-2024 provides a convenient solution for applications requiring multiple amplifiers. The pinout groups the four outputs for easy signal summing for circuits such as four-channel mixers.

PIN CONNECTIONS


## BLOCK DIAGRAM



The SSM-2024 is mask work protected under the Semiconductor Chip Protection Act of 1983.
This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

## ABSOLUTE MAXIMUM RATINGS

Supply Voltage ...................................................... 36V or $\pm 18 \mathrm{~V}$
Junction Temperature ................................................. $+150^{\circ} \mathrm{C}$
Operating Temperature Range .......................... -10 to $+50^{\circ} \mathrm{C}$
Storage Temperature Range ........................... -65 to $+150^{\circ} \mathrm{C}$
Maximum Current into Any Pin ....................................... 10mA
Lead Temperature Range (Soldering, 60 sec ) ............... $300^{\circ} \mathrm{C}$

| PACKAGE TYPE | $\Theta_{\mathrm{IA}}$ (Note 1) | $\Theta_{\mathrm{j} \mathrm{C}}$ | UNITS |
| :--- | :---: | :---: | :---: |
| 14-Pin Plastic DIP $(P)$ | 90 | 47 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

NOTES:

1. $\Theta_{\mathrm{i} A}$ is specified for worst case mounting conditions, i.e., $\Theta_{\mathrm{iA}}$ is specified for device in socket for P-DIP package.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | SSM-2024 |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX |  |
| Positive Supply Current | ${ }^{+}{ }_{S Y}$ | $\begin{aligned} & I_{\mathrm{CON}}(1-4)=0 \quad \mathrm{~V}_{\mathrm{S}}= \pm 15 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{CON}}(1-4)=0 \mathrm{~V}_{\mathrm{S}}= \pm 16.5 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 0.95 \\ & 1.05 \end{aligned}$ | $\begin{aligned} & 1.40 \\ & 1.55 \end{aligned}$ | $\begin{aligned} & 1.85 \\ & 2.05 \end{aligned}$ | mA |
| Negative Supply Current | ${ }^{-1} \mathrm{I}_{\mathrm{SY}}$ | $\begin{aligned} & I_{\operatorname{CoN}}(1-4)=0 \quad V_{S}= \pm 15 \mathrm{~V} \\ & I_{\operatorname{CoN}}(1-4)=0 \quad V_{\mathrm{S}}= \pm 16.5 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 1.05 \\ & 1.20 \end{aligned}$ | $\begin{aligned} & 1.55 \\ & 1.65 \end{aligned}$ | $\begin{aligned} & 2.05 \\ & 2.25 \end{aligned}$ | mA |
| Gain | G | $\mathrm{I}_{\text {CON }}(1-4)= \pm 500 \mu \mathrm{~A}$ | 3842 | 4085 | 4330 | $\mu \mathrm{mhos}$ |
| Gain Matching | $\Delta \mathrm{G}$ | $\mathrm{I}_{\text {CON }}(1-4)= \pm 500 \mu \mathrm{~A}$ | - | - | $\pm 6$ | \% |
| Input Offset Voltage | $\mathrm{V}_{\text {os }}$ | $\begin{aligned} & V_{\text {IN }}=0 \mathrm{~V} \mathrm{I}_{\mathrm{CON}}(1-4)= \pm 500 \mu \mathrm{~A} \\ & \mathrm{I}_{\mathrm{CON}}(1-4)=+250 \mu \mathrm{~A} \end{aligned}$ | - | $\pm .4$ | $\pm 1.3$ | mV |
| Change in Offset Voltage | $\Delta V_{\text {OS }}$ | $\begin{aligned} & +2.5 \mu \mathrm{~A} \leq \mathrm{I}_{\mathrm{CON}}(1-4) \leq+250 \mu \mathrm{~A} \\ & +250 \mathrm{nA} \leq \mathrm{I}_{\mathrm{CON}}(1-4) \leq+250 \mu \mathrm{~A} \end{aligned}$ | - | $\begin{aligned} & \pm 100 \\ & \pm 250 \end{aligned}$ | $\begin{aligned} & \pm 840 \\ & \pm 840 \end{aligned}$ | $\mu \mathrm{V}$ |
| Output Leakage | $\mathrm{I}_{\mathrm{OL}}$ | $\mathrm{I}_{\mathrm{CON}}(1-4)=0$ | - | 0.1 | $\pm 5$ | nA |
| Control Rejection (Untrimmed) | CVR | $\begin{aligned} & \mathrm{I}_{\mathrm{CON}}(1-4)=500 \mu \mathrm{~A} \\ & \mathrm{~V}_{\mathrm{IN}}(1-4)=40 \mathrm{mV} \mathrm{~V}_{\mathrm{p}-\mathrm{p}} \end{aligned}$ | 30 | 41.5 | - | dB |
| Signal-to-Noise | $\mathrm{S} / \mathrm{N}$ | $\mathrm{V}_{\mathrm{IN}}(1-4)=40 \mathrm{mV} \mathrm{V}_{\mathrm{p}}$ | - | 82 | - | dB |
| Distortion | THD | $\mathrm{V}_{\mathrm{IN}}(1-4)=40 \mathrm{mV} \mathrm{V}_{\mathrm{p}}$ | - | 0.3 | - | \% |
| Threshold Input Control Voltage | $\mathrm{V}_{\text {TCI }}$ | $\mathrm{I}_{\text {OUT }}(1-4)=0$ | +160 | - | +220 | mV |

NOTE: Specifications subject to change; consult latest data sheet.

SIMPLIFIED SCHEMATIC (1 OF 4 AMPLIFIERS)


## FEATURES

## Excellent Sonic Characteristics

High Output Drive Capability
$5.2 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ Equivalent Input Noise @ 1 kHz
$0.001 \%$ THD+N ( $V_{0}=2.5 \mathrm{~V}$ p-p @ 1 kHz)
3.5 MHz Gain Bandwidth

Unity-Gain Stable
Low Cost

## APPLICATIONS

Multimedia Audio Systems
Microphone Preamplifier
Headphone Driver
Differential Line Receiver
Balanced Line Driver
Audio ADC Input Buffer
Audio DAC I-V Converter and Filter
Pseudo-Ground Generator

## GENERAL DESCRIPTION

The SSM-2135 Dual Audio Operational Amplifier permits excellent performance in portable or low power audio systems, with an operating supply range of +4 V to +36 V or $\pm 2 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$. The unity gain stable device has very low voltage noise of $4.7 \mathrm{nV} / \sqrt{\mathrm{Hz}}$, and total harmonic distortion plus noise below $0.01 \%$ over normal signal levels and loads. Such characteristics are enhanced by wide output swing and load drive capability. A unique output stage» permits output swing approaching the rail

PIN CONNECTIONS


8-Lead Epoxy DIP (P Suffix)

under moderate load conditions. Under severe loading, the SSM-2135 still maintains a wide output swing with ultralow distortion.

Particularly well suited for computer audio systems and portable digital audio units, the SSM-2135 can perform preamplification, headphone and speaker driving, and balanced line driving and receiving. Additionally, the device is ideal for input signal conditioning in single-supply sigma-delta analog-to-digital converter subsystems such as the AD1878/AD1879.
The SSM-2135 is available in 8-pin plastic DIP and SOIC packages, and is guaranteed for operation over the extended industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.
*Protected by U. S. Patent No. 5,146,181.

FUNCTIONAL BLOCK DIAGRAM


Typical specifications apply at $T_{A}=+25^{\circ} \mathrm{C}$.)
SSM2135

## Electrical Characteristics

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| AUDIO PERFORMANCE <br> Voltage Noise Density Current Noise Density Signal-To-Noise Ratio Headroom Total Harmonic Distortion | $\begin{aligned} & e_{n} \\ & i_{n} \\ & \text { SNR } \\ & \text { HR } \\ & \text { THD }+\mathrm{N} \end{aligned}$ | $\begin{aligned} & \mathrm{f}=1 \mathrm{kHz} \\ & \mathrm{f}=1 \mathrm{kHz} \\ & 20 \mathrm{~Hz} \text { to } 20 \mathrm{kHz}, 0 \mathrm{dBu}=0.775 \mathrm{~V} \mathrm{rms} \\ & \mathrm{Clip} \text { Point }=1 \% \mathrm{THD}+\mathrm{N}, \mathrm{f}=1 \mathrm{kHz}, \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \\ & \mathrm{~A}_{\mathrm{V}}=+1, \mathrm{~V}_{\mathrm{O}}=1 \mathrm{Vp}-\mathrm{p}, \mathrm{f}=1 \mathrm{kHz}, 80 \mathrm{kHz} \mathrm{LPF} \\ & \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}}=32 \Omega \end{aligned}$ |  | $\begin{aligned} & 5.2 \\ & 0.5 \\ & 121 \\ & 5.3 \\ & \\ & 0.003 \\ & 0.005 \end{aligned}$ |  | $\begin{aligned} & \mathrm{nV} / \sqrt{\mathrm{Hz}} \\ & \mathrm{pA} / \sqrt{\mathrm{Hz}} \\ & \mathrm{dBu} \\ & \mathrm{dBu} \\ & \\ & \% \\ & \% \end{aligned}$ |
| DYNAMIC PERFORMANCE <br> Slew Rate Gain Bandwidth Product Settling Time | SR GBW $\mathrm{t}_{\mathrm{s}}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \text { to } 0.1 \%, 2 \mathrm{~V} \text { Step } \end{aligned}$ | 0.6 | $\begin{aligned} & 0.9 \\ & 3.5 \\ & 5.8 \end{aligned}$ |  | V/us MHz $\mu \mathrm{s}$ |
| INPUT CHARACTERISTICS <br> Input Voltage Range Input Offset Voltage Input Bias Current Input Offset Current Differential Input Impedance Common-Mode Rejection Large Signal Voltage Gain | $\mathrm{V}_{\mathrm{CM}}$ <br> $\mathrm{V}_{\mathrm{OS}}$ <br> $\mathrm{I}_{\mathrm{B}}$ <br> $\mathrm{I}_{\mathrm{OS}}$ <br> $\mathrm{Z}_{\mathrm{IN}}$ <br> CMR <br> $\mathrm{A}_{\mathrm{vo}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{OUT}}=2 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{OUT}}=2 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CM}}=0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V} \\ & 0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CM}} \leq 4 \mathrm{~V}, \mathrm{f}=\mathrm{dc} \\ & 0.01 \mathrm{~V} \leq \mathrm{V}_{\text {OUT }} \leq 3.9 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=600 \Omega \end{aligned}$ |  | $\begin{aligned} & 0.2 \\ & 300 \\ & 4 \\ & 112 \end{aligned}$ | $\begin{aligned} & +4.0 \\ & 2.0 \\ & 750 \\ & 50 \end{aligned}$ | V <br> mV <br> nA <br> nA <br> $\mathrm{M} \Omega$ <br> dB <br> $\mathrm{V} / \mu \mathrm{V}$ |
| OUTPUT CHARACTERISTICS <br> Output Voltage Swing High <br> Output Voltage Swing Low <br> Short Circuit Current Limit | $\begin{aligned} & \mathrm{V}_{\mathrm{OH}} \\ & \mathrm{~V}_{\mathrm{OL}} \\ & \mathrm{I}_{\mathrm{SC}} \end{aligned}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=100 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}}=600 \Omega \\ & \mathrm{R}_{\mathrm{L}}=100 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}}=600 \Omega \end{aligned}$ | $\begin{aligned} & 4.1 \\ & 3.9 \end{aligned}$ | $\pm 30$ | $\begin{aligned} & 3.5 \\ & 3.0 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{mV} \\ & \mathrm{mV} \\ & \mathrm{~mA} \end{aligned}$ |
| POWER SUPPLY <br> Supply Voltage Range <br> Power Supply Rejection Ratio Supply Current | $\begin{aligned} & \mathrm{V}_{\mathrm{S}} \\ & \mathrm{PSRR} \\ & \mathrm{I}_{\mathrm{SY}} \end{aligned}$ | Single Supply <br> Dual Supply $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=+4 \mathrm{~V} \text { to }+6 \mathrm{~V}, \mathrm{f}=\mathrm{dc} \\ & \mathrm{~V}_{\text {OUT }}=2.0 \mathrm{~V}, \text { No Load } \\ & \mathrm{V}_{\mathrm{S}}=+5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 18 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & +4 \\ & \pm 2 \\ & 90 \end{aligned}$ | $\begin{aligned} & 120 \\ & 2.8 \\ & 3.7 \end{aligned}$ | $\begin{aligned} & +36 \\ & +18 \\ & \\ & 4.0 \\ & 5.0 \end{aligned}$ | V dB <br> mA <br> mA |

ABSOLUTE MAXIMUM RATINGS
Supply Voltage
Single Supply ..... 36 V
Dual Supply ..... 18 V
Input Voltage ..... $\pm V_{S}$
Differential Input Voltage ..... 10 V
Output Short Circuit Duration ..... Indefinite
Storage Temperature Range ..... $65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Operating Temperature Range ..... $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Junction Temperature Range ( $\mathrm{T}_{\mathrm{J}}$ ) . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 60 sec ) ..... $+300^{\circ} \mathrm{C}$
ESD RATINGS
883 (Human Body) Model ..... 1 kV
EIAJ Model ..... 175 V

THERMAL CHARACTERISTICS
Thermal Resistance ${ }^{1}$

8-Pin Plastic DIP
8-Pin SOIC
$\theta_{\mathrm{JA}}$
$\theta_{\mathrm{JC}}$
$\boldsymbol{\theta}_{\mathrm{J}}$
$\theta_{\mathrm{J}}$
$103^{\circ} \mathrm{C} / \mathrm{W}$ $43^{\circ} \mathrm{C} / \mathrm{W}$ $158^{\circ} \mathrm{C} / \mathrm{W}$ $43^{\circ} \mathrm{C} / \mathrm{W}$
${ }^{1} \theta_{\mathrm{IA}}$ is specified for worst case conditions, i.e., $\theta_{\mathrm{IA}}$ is specified for device in socket for P-DIP and device soldered in circuit board for SOIC package.

## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| SSM2135P | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | N-8 |
| SSM2135S | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Narrow Body | SO-8 |

[^216]

Figure 1. Test Circuit for Figures 2-4


Figure 2. $T H D+N$ vs. Amplitude (See Test Circuit; $A_{V}=$ $+1, V_{s}=+5 \mathrm{~V}, f=1 \mathrm{kHz}$, with 80 kHz Low-Pass Filter)


Figure 3. THD+N vs. Frequency (See Test Circuit; $A_{V}=+1, V_{I N}=1 \mathrm{~V} p-\mathrm{p}$, with 80 kHz Low-Pass Filter)


Figure 4. $T H D+N$ vs. Load (See Test Circuit)


Figure 5. THD $+N$ vs. Gain


Figure 6. THD $+N$ vs. Supply Voltage


Figure 7. SMPTE Intermodulation Distortion $\left(A_{V}=+1\right.$, $\left.V_{S}=+5 \mathrm{~V}, f=1 \mathrm{kHz}, R_{L}=10 \mathrm{kS}\right)$


Figure 8. Input Voltage Noise (20 nV/div)


Figure 9. Voltage Noise Density vs. Frequency


Figure 10. Current Noise Density vs. Frequency


Figure 11. Frequency Response ( $A_{V}=+1, V_{s}=+5 \mathrm{~V}$, $\left.V_{I N}=1 \mathrm{Vp}-\mathrm{p}, R_{\mathrm{L}}=10 \mathrm{k} \Omega\right)$


Figure 12. Square Wave Response $\left(V_{S}=+5 V, A_{V}=+1\right.$, $\left.R_{L}=x\right)$


Figure 13. Crosstalk vs. Frequency ( $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ )


Figure 14. Common-Mode Rejection vs. Frequency


Figure 15. Power Supply Rejection vs. Frequency


Figure 16. Closed-Loop Gain vs. Frequency


Figure 17. Open-Loop Gain and Phase vs. Frequency


Figure 18. Small Signal Overshoot vs. Load Capacitance


Figure 19. Output Impedance vs. Frequency


Figure 20. Maximum Output Voltage vs. Load Resistance


Figure 21. Maximum Output Swing vs. Frequency


Figure 22. Output Swing vs. Supply Voltage


Figure 23. Output Swing vs. Temperature and Load


Figure 24. Slew Rate vs. Temperature


Figure 25. Open-Loop Gain vs. Temperature


Figure 26. Gain Bandwidth Product and Phase Margin vs. Temperature


Figure 27. Supply Current vs. Temperature


Figure 28. Input Bias Current vs. Temperature

## APPLICATION INFORMATION

The SSM-2135 is a low voltage audio amplifier that has exceptionally low noise and excellent sonic quality even when driving loads as small as $25 \Omega$. Designed for single supply use, the SSM-2135's inputs common-mode and output swing to zero volts. Thus with a supply voltage at +5 V , both the input and output will swing from 0 V to +4 V . Because of this, signal dynamic range can be optimized if the amplifier is biased to a +2 V reference rather than at half the supply voltage.
The SSM-2135 is unity-gain stable, even when driving into a fair amount of capacitive load. Driving up to 500 pF does not cause any instability in the amplifier. However, overshoot in the frequency response increases slightly.
The SSM-2135 makes an excellent output amplifier for +5 V only audio systems such as a multimedia workstation, a CD output amplifier, or an audio mixing system. The amplifier has large output swing even at this supply voltage because it is designed to swing to the negative rail. In addition, it easily drives load impedances as low as $25 \Omega$ with low distortion.
The SSM-2135 is fully protected from phase reversal for inputs going to the negative supply rail. However, an internal ESD protection diodes will turn "on" when either input is forced more than 0.5 V below the negative rail. Under this condition, input current in excess of 2 mA may cause erratic output behavior, in which case a current limiting resistor should be included in the offending input if phase integrity is required with excessive input voltages. A $500 \Omega$ or higher series input resistor will prevent phase inversion even with the input pulled 1 volt below the negative supply.
"Hot" plugging the input to a signal generally does not present a problem for the SSM-2135, assuming the signal does not have any voltage exceeding the device's supply voltage. If so, it is advisable to add a series input resistor to limit the current, as well as a Zener diode to clamp the input to a voltage no higher than the supply.

## APPLICATION CIRCUITS

## A Low Noise Stereo Headphone Driver Amplifier

Figure 29 shows the SSM-2135 used in a stereo headphone driver for multimedia applications with the AD1848, a 16-bit stereo codec. The SSM-2135 is equally well suited for the serialbused AD1849 stereo codec. The headphone's impedance can be as low as $25 \Omega$, which covers most commercially available high fidelity headphones. Although the amplifier can operate at up to $\pm 18 \mathrm{~V}$ supply, it is just as efficient powered by a single +5 V . At this voltage, the amplifier has sufficient output drive to deliver distortion-free sound to a low impedance headphone.


Figure 29: A Stereo Headphone Driver for Multimedia Sound Codec

Figure 30 shows the total harmonic distortion characteristics versus frequency driving into a $32 \Omega$ load, which is a very typical impedance for a high quality stereo headphone. The SSM2135 has excellent power supply rejection, and as a result, is tolerant of poorly regulated supplies. However, for best sonic quality, the power supply should be well regulated and heavily bypassed to minimize supply modulation under heavy loads. A minimum of $10 \mu \mathrm{~F}$ bypass is recommended.


Figure 30. Headphone Driver $T H D+N$ vs. Frequency into a $32 \Omega$ Load ( $V_{s}=+5 \mathrm{~V}$, with 80 kHz Low-Pass Filter)

## A Low Noise Microphone Preamplifier

The SSM-2135's $4.7 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ input noise in conjunction with low distortion makes it an ideal device for amplifying low level signals such as those produced by microphones. Figure 31 illustrates a stereo microphone input circuit feeding a multimedia sound codec. As shown, the gain is set at $100(40 \mathrm{~dB})$, although it can be set to other gains depending on the microphone output levels. Figure 32 shows the preamplifier's harmonic distortion performance with 1 V rms output while operating from a single +5 V supply.
The SSM-2135 is biased to 2.25 V by the $\mathrm{V}_{\text {REF }}$ pin of the AD1848 codec. The same voltage is buffered by the 2N4124 transistor to provide "phantom power" to the microphone. A typical electret condenser microphone with an impedance range of $100 \Omega$ to $1 \mathrm{k} \Omega$ works well with the circuit. This power booster circuit may be omitted for dynamic microphone elements.


Figure 31. Low Noise Microphone Preamp for Multimedia Sound Codec


Figure 32. MIC Preamp THD $+N$ Performance ( $V_{s}=+5 V$, $A_{V}=40 \mathrm{~dB}, V_{\text {Out }}=1 \mathrm{Vrms}$, with 80 kHz Low-Pass Filter)

## An 18-Bit Stereo CD-DAC Output Amplifier

The SSM-2135 makes an ideal single supply stereo output amplifier for audio D/A converters because of its low noise and distortion. Figure 33 shows the implementation of an 18 -Bit stereo DAC channel. The output amplifier also provides low-pass filtering for smoothing the oversampled audio signal. The filter's cutoff frequency is set at 22.5 kHz and it has a maximally flat response from dc to 20 kHz .
As mentioned above, the amplifier's outputs can drive directly into a stereo headphone that has impedance as low as $25 \Omega$ with no additional buffering required.


Figure 33. +5 V Stereo 18-Bit DAC

## A Single Supply Differential Line Driver

Signal distribution and routing is often required in audio systems, particularly portable digital audio equipment for professional applications. Figure 34 shows a single supply line driver circuit that has differential output. The bottom amplifier provides a 2 V dc bias for the differential amplifier in order to maximize the output swing range. The amplifier can output a maximum of 0.8 V rms signal with a +5 V supply. It is capable of driving into $600 \Omega$ line termination at a reduced output amplitude.


Figure 34. Single Supply Differential Line Driver

## A Single Supply Differential Line Receiver

Receiving a differential signal with minimum distortion is achieved using the circuit in Figure 35: Unlike a difference amplifier (a subtractor), the circuit has a true balanced input impedance regardless of input drive levels. That is, each input always presents a $20 \mathrm{k} \Omega$ impedance to the source. For best common-mode rejection performance, all resistors around the differential amplifier must be very well matched. Best results can be achieved using a $10 \mathrm{k} \Omega$ precision resistor network.


Figure 35. Single Supply Balanced Differential Line Receiver

## A Pseudo-Reference Voltage Generator

For single supply circuits, a reference voltage source is often required for biasing purposes or signal offsetting purposes. The circuit in Figure 36 provides a supply splitter function with low output impedance. The $1 \mu \mathrm{~F}$ output capacitor serves as a charge reservoir to handle a sudden surge in demand by the load as well as providing a low ac impedance to it. The $0.1 \mu \mathrm{~F}$ feedback capacitor compensates the amplifier in the presence of a heavy capacitive load, maintaining stability.
The output can source or sink up to 12 mA of current with +5 V supply, limited only by the $100 \Omega$ output resistor. Reducing the resistance will increase the output current capability. Alternatively, increasing the supply voltage to 12 V also improves the output drive to more than 25 mA .


Figure 36. Pseudo-Reference Generator

## A Digital Volume Control Circuit

Working in conjunction with the AD7528/PM7528 dual 8-bit D/A converter, the SSM-2135 makes for an efficient audio attenuator, as shown in Figure 37. The circuit works off a single +5 V supply. The DAC's are biased to a 2 V reference level which is sufficient to keep the DAC's internal R-2R ladder switches operating properly. This voltage is also the optimal midpoint of the SSM-2135's common-mode and output swing range. With the circuit as shown, the maximum input and output swing is 1.25 V rms . Total harmonic distortion measures a respectable $0.01 \%$ at 1 kHz and $0.1 \%$ at 20 kHz . The frequency response at any attenuation level is flat to 20 kHz .
Each DAC can be controlled independently via the 8-bit parallel data bus. The attenuation level is linearly controlled by the binary weighting of the digital data input. Total attenuation ranges from 0 dB to -48 dB .


Figure 37. Digital Volume Control

## A Logarithmic Volume Control Circuit

Figure 38 shows a logarithmic version of the volume control function. Similar biasing is used. With an 8 -bit bus, the AD7111 provides an 88.5 dB attenuation range. Each bit resolves a 0.375 dB attenuation. Refer to AD7111 data sheet for attenuation levels for each input code.


Figure 38. Single Supply Logarithmic Volume Control

## FEATURES



## APPLICATIONS

- Line Receivers
- Summing Amplifiers
- Buffer Amplifiers - Drives 600 2 Load


## ORDERING INFORMATION

|  | PACKAGE |  |
| :---: | :---: | :---: |
| PLASTIC | NARROW BODY SO | OPERATING |
| 8-PIN | TEMPERATURE |  |
| 8-PIN | RANGE |  |
| SSM2141P | SSM2141S | XIND $\left(-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}\right)$ |

## FUNCTIONAL DIAGRAM



## GENERAL DESCRIPTION

The SSM-2141 is an integrated differential amplifier intended to receive balanced line inputs in audio applications requiring a high level of noise immunity and optimum common-mode rejection. The SSM-2141 typically achieves 100 dB of common-mode rejection (CMR), whereas implementing an op amp with four off-the-shelf precision resistors will typically achieve only 40 dB of CMR - inadequate for high-performance audio.
The SSM-2141 achieves low distortion performance by maintaining a large slew rate of $9.5 \mathrm{~V} / \mu$ s and high open-loop gain. Distortion is less than $0.002 \%$ over the full audio bandwidth. The SSM-2141 complements the SSM-2142 balanced line driver. Together, these devices comprise a fully integrated solution for equivalent transformer balancing of audio signals without the problems of distortion, EMI fields, and high cost.

Additional applications for the SSM-2141 include summing signals, differential preamplifiers, and $600 \Omega$ low distortion buffer amplifiers.

## PIN CONNECTIONS



This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

ABSOLUTE MAXIMUM RATINGS (Note 1)


| PACKAGE TYPE | $\boldsymbol{\theta}_{\boldsymbol{\mu}}$ (Note 2) | $\boldsymbol{\theta}_{\boldsymbol{\kappa}}$ | UNITS |
| :--- | :---: | :---: | :---: |
| 8-Pin Plastic DIP (P) | 103 | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTES:

1. For supply voltages less than $\pm 18 \mathrm{~V}$, the absolute maximum input voltage is equal to the supply voltage.
2. $\Theta_{i \mathrm{~A}}$ is specified for worst case mounting conditions, i.e., $\Theta_{i \wedge}$ is specified for device in socket for P-DIP package.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 18 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.

| PARAMETER | SYMBOL | CONDITIONS | MIN | $\begin{gathered} \text { SSM-2141 } \\ \text { TYP } \end{gathered}$ | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Offset Voltage | $\mathrm{V}_{\text {os }}$ | $V_{C M}=0 \mathrm{~V}$ | -1000 | 25 | 1000 | $\mu \mathrm{V}$ |
| Gain Error |  | No Load, $\mathrm{V}_{10}= \pm 10 \mathrm{~V}, \mathrm{R}_{\mathrm{S}}=0 \Omega$ | - | 0.001 | 0.01 | \% |
| Input Voltage Range | IVR | (Note 1) | $\pm 10$ | - | - | V |
| Common-Mode Rejection | CMR | $V_{C M}= \pm 10 \mathrm{~V}$ | 80 | 100 | - | dB |
| Power Supply Rejection Ratio | PSRR | $V_{\text {S }}= \pm 6 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | 0.7 | 15 | $\mu \mathrm{V} N$ |
| Output Swing | $V_{0}$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \boldsymbol{\Omega}$ | $\pm 13$ | $\pm 14.7$ | - | $v$ |
| Short-Circuit Current Limit | $\mathrm{I}_{\text {sc }}$ | Output Shorted To Ground | +45/-15 | - | - | mA |
| Small-Signal Bandwidth (-3dB) | BW | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | - | 3 | - | MHz |
| Slew Rate | SR | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | 6 | 9.5 | - | V/us |
| Total Harmonic Distortion | THD | $\begin{aligned} & R_{L}=100 \mathrm{k} \Omega \\ & R_{L}=600 \Omega \end{aligned}$ | - | $\begin{array}{r} 0.001 \\ 0.01 \end{array}$ | - | \% |
| Capacitive Load Drive Capability | $C_{L}$ | No Oscillation | - | 300 | - | pF |
| Supply Current | $\mathrm{I}_{\mathrm{SY}}$ | No Load | - | 2.5 | 3.5 | mA |

NOTE:

1. Input voltage range guaranteed by CMR test.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}= \pm 18 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$.

| PARAMETER | SYMBOL | CONDITIONS | MIN | $\begin{gathered} \text { SSM-2141 } \\ \text { TYP } \end{gathered}$ | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Offset Voltage | $V_{\text {os }}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | -2500 | 200 | 2500 | $\mu \mathrm{V}$ |
| Gain Error |  | No Load, $\mathrm{V}_{\text {IN }}= \pm 10 \mathrm{~V}, \mathrm{R}_{\mathrm{S}}=0 \Omega$ | - | 0.002 | 0.02 | \% |
| Input Voltage Range | IVR | (Note 1) | $\pm 10$ | - | - | V |
| Common-Mode Rejection | CMR | $\mathrm{V}_{\mathrm{CM}}= \pm 10 \mathrm{~V}$ | 75 | 90 | - | dB |
| Power Supply Rejection Ratio | PSRR | $\mathrm{V}_{\mathrm{S}}= \pm 6 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | - | 1.0 | 20 | $\mu \mathrm{V} / \mathrm{N}$ |
| Output Swing | $V_{0}$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | $\pm 13$ | $\pm 14.7$ | - | V |
| Slew Rate | SR | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | - | 9.5 | - | $\mathrm{V} / \mu \mathrm{s}$ |
| Supply Current | $\mathrm{I}_{\mathrm{SY}}$ | No Load | - | 2.6 | 4.0 | mA |

## NOTE:

1. Input voltage range guaranteed by CMR test.

FEATURES
Transformer-Like Balanced Output
Drives 10 V RMS Into a $\mathbf{6 0 0} \boldsymbol{\Omega}$ Load
Stable When Driving Large Capacitive Loads and Long Cables
Low Distortion
$0.006 \%$ typ $20 \mathrm{~Hz}-20 \mathrm{kHz}, 10 \mathrm{~V}$ RMS into $600 \Omega$
High Slew Rate
15 V/us typ
Low Gain Error
(Differential or Single-Ended); 0.7\% typ
Outputs Short-Circuit Protected
Available In Space-Saving 8-Pin Mini-DIP Package Low Cost
APPLICATIONS
Audio Mix Consoles
Distribution Amplifiers
Graphic and Parametric Equalizers
Dynamic Range Processors
Digital Effects Processors
Telecommunications Systems
Industrial Instrumentation
Hi-Fi Equipment

## GENERAL DESCRIPTION

The SSM-2142 is an integrated differential-output buffer amplifier that converts a single-ended input signal to a balanced output signal pair with high output drive. By utilizing low noise thermally matched thin film resistors and high slew rate amplifiers, the SSM-2142 helps maintain the sonic quality of audio systems by eliminating power line hum, RF interference, voltage drops, and other externally generated noise commonly encountered with long audio cable runs. Excellent rejection of common-mode noise and offset errors is achieved by laser trimming of the onboard resistors, assuring high gain accuracy. The carefully designed output stage of the SSM-2142 is capable of driving difficult loads, yielding low-distortion performance despite extremely long cables or loads as low as $600 \Omega$, and is stable over a wide range of operating conditions.
Based on a cross-coupled, electronically balanced topology, the SSM-2142 mimics the performance of fully balanced transformer-based solutions for line driving. However, the SSM2142 maintains lower distortion and occupies much less board space than transformers while achieving comparable commonmode rejection performance with reduced parts count.

FUNCTIONAL BLOCK DIAGRAM


The SSM-2142 in tandem with the SSM-2141 differential receiver establishes a complete, reliable solution for driving and receiving audio signals over long cables. The SSM-2141 features an Input Common-Mode Rejection Ratio of 100 dB at 60 Hz . Specifications demonstrating the performance of this typical system are included in the data sheet.

## PIN CONNECTIONS

8-Pin Plastic DIP
(P Suffix)
8-Pin Cerdip
(Z Suffix)


16-Pin
Wide Body SOL
(S Suffix)


SPEGFGATMNS $\left(V_{S}= \pm 18 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}\right.$, operating in differential mode unless indicated otherwise. Typical characteristics apply to operation at $\mathrm{T}_{A}=+25^{\circ} \mathrm{C}$.)

SSM2142

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT IMPEDANCE | $\mathrm{Z}_{\text {IN }}$ |  |  | 10 |  | k $\Omega$ |
| INPUT CURRENT | $\mathrm{I}_{\text {IN }}$ | $\mathrm{V}_{\text {IN }}= \pm 7.071 \mathrm{~V}$ |  | $\pm 750$ | $\pm 900$ | $\mu \mathrm{A}$ |
| GAIN, DIFFERENTIAL |  |  | 5.8 | 5.98 |  | dB |
| GAIN, SINGLE-ENDED |  | Single-Ended Mode | 5.7 | 5.94 |  | dB |
| GAIN ERROR, DIFFERENTIAL |  | $\mathrm{R}_{\mathrm{L}}=600 \Omega$ |  | 0.7 | 2 | \% |
| POWER SUPPLY REJECTION RATIO STATIC | PSRR | $\mathrm{V}_{\mathrm{S}}= \pm 13 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | 60 | 80 |  | dB |
| OUTPUT COMMON-MODE REJECTION | OCMR | See Test Circuit; $\mathrm{f}=1 \mathrm{kHz}$ | -38 | -45 |  | dB |
| OUTPUT SIGNAL BALANCE RATIO | SBR | See Test Circuit; f = 1 kHz | -35 | -40 |  | dB |
| TOTAL HARMONIC DISTORTION Plus Noise | THD + N | $\begin{aligned} & 20 \mathrm{~Hz} \text { to } 20 \mathrm{kHz}, \\ & \mathrm{~V}_{\mathrm{O}}=10 \mathrm{~V} \mathrm{rms}, \mathrm{R}_{\mathrm{L}}=600 \Omega \end{aligned}$ |  | 0.006 |  | \% |
| SIGNAL-TO-NOISE RATIO | SNR | $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ |  | -93.4 |  | dBu |
| HEADROOM | HR | CLIP Level $=10.5 \mathrm{~V} \mathrm{rms}$ |  | +93.4 |  | dBu |
| SLEW RATE | SR |  |  | 15 |  | $\mathrm{V} / \mu \mathrm{s}$ |
| OUTPUT COMMON-MODE VOLTAGE OFFSET ${ }^{1}$ | $\mathrm{V}_{\text {oos }}$ | $\mathrm{R}_{\mathrm{L}}=600 \Omega$ | $-250$ | 25 | 250 | mV |
| DIFFERENTIAL OUTPUT VOLTAGE OFFSET | $\mathrm{V}_{\text {OOD }}$ | $\mathrm{R}_{\mathrm{L}}=600 \Omega$ | -50 | 15 | 50 | mV |
| DIFFERENTIAL OUTPUT VOLTAGE SWING |  | $\mathrm{V}_{\text {IN }}= \pm 7.071 \mathrm{~V}$ | $\pm 13.8$ | $\pm 14.14$ |  | V |
| OUTPUT IMPEDANCE | $\mathrm{Z}_{\mathrm{O}}$ |  | 45 | 50 | 55 | $\Omega$ |
| SUPPLY CURRENT | $\mathrm{I}_{\mathrm{SY}}$ | Unloaded, $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}$ |  | 5.5 | 7.0 | mA |
| OUTPUT CURRENT, SHORT CIRCUIT | $\mathrm{I}_{\mathrm{SC}}$ |  | 60 | 70 |  | mA |

NOTE
${ }^{1}$ Output common-mode offset voltage can be removed by inserting dc blocking capacitors in the sense lines. See the Applications Information.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS*

Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 18$ V Storage Temperature . . . . . . . . . . . . . . . . $-60^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ Lead Temperature (Soldering, 60 sec ) . . . . . . . . . . $+300^{\circ} \mathrm{C}$ Junction Temperature . . . . . . . . . . . . . . . . . . . . . . $+150^{\circ} \mathrm{C}$ Operating Temperature Range . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ Output Short Circuit Duration (Both Outputs) . . . . . Indefinite
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; the functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.


Typical Application of the SSM-2142 and SSM-2141

ORDERING GUIDE

| Model | Operating <br> Temperature Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| SSM2142P | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Plastic DIP | $\mathrm{N}-8$ |
| SSM2142Z | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Cerdip | Q-8 |
| SSM2142S ${ }^{2}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | SOL | R-16 |

[^217]-6 dB Differential Line Receiver
SSM2143

## FEATURES

High Common-Mode Rejection
DC: 90 dB typ
60 Hz : 90 dB typ
20 kHz : 85 dB typ
Ultralow THD: 0.0006\% typ @ 1 kHz
Fast Slew Rate: $10 \mathrm{~V} / \mu \mathrm{s}$ typ
Wide Bandwidth: 7 MHz typ ( $G=1 / 2$ )
Two Gain Levels Available: $G=1 / 2$ or 2
Low Cost

## GENERAL DESCRIPTION

The SSM-2143 is an integrated differential amplifier intended to receive balanced line inputs in audio applications requiring a high level of immunity from common-mode noise. The device provides a typical 90 dB of common-mode rejection (CMR), which is achieved by laser trimming of resistances to better than $0.005 \%$.

Additional features of the device include a slew rate of $10 \mathrm{~V} / \mu \mathrm{s}$ and wide bandwidth. Total harmonic distortion (THD) is less than $0.004 \%$ over the full audio band, even while driving low impedance loads. The SSM-2143 input stage is designed to handle input signals as large as +28 dBu at $\mathrm{G}=1 / 2$. Although primarily intended for $G=1 / 2$ applications, a gain of 2 can be realized by reversing the $+\mathrm{IN} /-\mathrm{IN}$ and SENSE/REFERENCE connections.
When configured for a gain of $1 / 2$, the SSM-2143 and SSM-2142 Balanced Line Driver provide a fully integrated, unity gain solution to driving audio signals over long cable runs.

FUNCTIONAL BLOCK DIAGRAM


## PIN CONNECTIONS

Epoxy Mini-DIP (P Suffix)
and
SOIC (S Suffix)


This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

SPECIFICATIONS
$\left(V_{S}= \pm 15 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}, \mathrm{G}=1 / 2\right.$, unless otherwise specified.
Typical specifications apply at $T_{A}=+25^{\circ} \mathrm{C}$.)

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| AUDIO PERFORMANCE <br> Total Harmonic Distortion Plus Noise Signal-to-Noise Ratio Headroom | $\begin{aligned} & \text { THD }+\mathrm{N} \\ & \text { SNR } \\ & \text { HR } \end{aligned}$ | $\mathrm{V}_{\mathrm{IN}}=10 \mathrm{~V} \mathrm{rms}, \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega, \mathrm{f}=1 \mathrm{kHz}$ $0 \mathrm{dBu}=0.775 \mathrm{~V} \mathrm{rms}, 20 \mathrm{kHz}$ BW, RTI Clip Point $=1 \%$ THD +N |  | $\begin{aligned} & 0.0006 \\ & -107.3 \\ & +28.0 \end{aligned}$ |  | \% <br> dBu <br> dBu |
| DYNAMIC RESPONSE <br> Slew Rate <br> Small Signal Bandwidth | $\begin{aligned} & \mathrm{SR} \\ & \mathrm{BW}_{-3 \mathrm{~dB}} \end{aligned}$ | $\begin{aligned} R_{\mathbf{L}} & =2 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=200 \mathrm{pF} \\ \mathrm{R}_{\mathrm{L}} & =2 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=200 \mathrm{pF} \\ \mathrm{G} & =1 / 2 \\ \mathrm{G} & =2 \end{aligned}$ |  | $\begin{aligned} & 10 \\ & 7 \\ & 3.5 \end{aligned}$ |  | $\mathrm{V} / \mu \mathrm{s}$ <br> MHz <br> MHz |
| INPUT <br> Input Offset Voltage Common-Mode Rejection <br> Power Supply Rejection Input Voltage Range | $\mathrm{V}_{\mathrm{IOS}}$ CMR <br> PSR <br> IVR | $\begin{aligned} & \mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}, \mathrm{RTI}, \mathrm{G}=2 \\ & \mathrm{~V}_{\mathrm{CM}}= \pm 10 \mathrm{~V}, \mathrm{RTO} \\ & \mathrm{f}=\mathrm{dc} \\ & \mathrm{f}=60 \mathrm{~Hz} \\ & \mathrm{f}=20 \mathrm{kHz} \\ & \mathrm{f}=400 \mathrm{kHz} \\ & \mathrm{~V}_{\mathrm{S}}= \pm 6 \mathrm{~V} \text { to } \pm 18 \mathrm{~V} \\ & \text { Common Mode } \\ & \text { Differential } \end{aligned}$ | $-1.2$ <br> 70 <br> 90 | $\begin{aligned} & 0.05 \\ & 90 \\ & 90 \\ & 85 \\ & 60 \\ & 110 \\ & \pm 15 \\ & \pm 28 \end{aligned}$ | +1.2 | mV <br> dB <br> dB <br> dB <br> dB <br> dB <br> V <br> V |
| OUTPUT <br> Output Voltage Swing <br> Minimum Resistive Load Drive Maximum Capacitive Load Drive Short Circuit Current Limit | $\begin{aligned} & \mathrm{V}_{\mathrm{O}} \\ & \mathrm{I}_{\mathrm{sc}} \end{aligned}$ | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ | $\pm 13$ | $\begin{aligned} & \pm 14 \\ & 2 \\ & 300 \\ & +45,-20 \end{aligned}$ |  | V <br> $\mathrm{k} \Omega$ <br> pF <br> mA |
| GAIN Gain Accuracy |  |  | -0.1 | 0.03 | 0.1 | \% |
| REFERENCE INPUT <br> Input Resistance Voltage Range | . |  |  | $\begin{aligned} & 18 \\ & \pm 10 \end{aligned}$ |  | $\begin{aligned} & \mathrm{k} \Omega \\ & \mathrm{~V} \end{aligned}$ |
| POWER SUPPLY <br> Supply Voltage Range Supply Current | $\begin{aligned} & \mathrm{V}_{\mathrm{S}} \\ & \mathrm{I}_{\mathrm{SY}} \end{aligned}$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=\infty$ | $\pm 6$ | $\pm 2.7$ | $\begin{aligned} & \pm 18 \\ & \pm 4.0 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~mA} \end{aligned}$ |

Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS

Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . . 18 V
Common-Mode Input Voltage . . . . . . . . . . . . . . . . . . 22 V
Differential Input Voltage . . . . . . . . . . . . . . . . . . . . . $\pm 44$ V
Output Short Circuit Duration . . . . . . . . . . . . . . .Continuous
Operating Temperature Range. . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Junction Temperature (Tj). . . . . . . . . . . . . . . . . . . . $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 60 sec.) . . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Thermal Resistance
8-Pin Plastic DIP (P): $\theta_{\mathrm{JA}}=103, \theta_{\mathrm{JC}}=43 \ldots \ldots . . .{ }^{\circ} \mathrm{C} / \mathrm{W}$
8 -Pin SOIC (S): $\theta_{\mathrm{JA}}=150, \theta_{\mathrm{JC}}=43 \ldots . . . . . .^{\circ} \mathrm{C} / \mathrm{W}$

ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| SSM2143P | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Plastic DIP | N-8 <br> SSM2143S |
| $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin SOIC | SO-8 |  |

[^218]FEATURES
Digitally-Controlled "Clickless" Level Adjustment SSM2160: Six Channels
SSM2161: Four Channels
Master Control Has 1281 dB Steps
Each Channel Has 321 dB Steps Plus Mute
Step Sizes Can Be Changed Using External Resistors
High Gain Accuracy
100 dB Gain Range
Excellent Audio Characteristics:
-100 dBu SNR ( $0 \mathrm{dBu}=\mathbf{0 . 7 7 5} \mathrm{V}$ rms, $\mathrm{V}_{\mathrm{s}}= \pm 5 \mathrm{~V}$ )
+10 dBu Headroom ( $\mathrm{V}_{\mathrm{S}}= \pm 5 \mathrm{~V}$ )
$\mathbf{0 . 0 0 8 \%}$ THD+N(@1 kHz, $\mathrm{V}_{\mathbf{I N}}=\mathbf{- 1 0} \mathbf{~ d B u}$, Unity Gain)
-80 dB Crosstalk (@ 1 kHz)

## Single or Dual Supply Operation

24-Pin Plastic DIP and SOIC Packages (SSM2160)
20-Pin Plastic DIP and SOIC Packages (SSM2161)

## APPLICATIONS

## Dolby* Pro-Logic Master Volume Control

Home THX $\dagger$ System
DSP Soundfield Processors
Automotive Audio Systems HDTV Audio Systems

## GENERAL DESCRIPTION

The SSM2160 and SSM2161 allow digital control of volume for six and four channels, respectively, with a master level control. In order to avoid "clicking," the device uses high performance voltage controlled amplifiers (VCAs) for the audio signal path.' The VCA control port effectively isolates DAC charge injection from the audio path, which is the major contributor to clicking in resistor-ladder type attenuators. Each channel is controlled by a dedicated 5-bit DAC, providing 32 steps of adjustment, plus

FUNCTIONAL BLOCK DIAGRAM

mute. In addition, a master 7-bit DAC feeds every control port, with 128 steps. Therefore, a balance can be achieved among all channels over a 32 -step range, and the master control allows adjustment over its entire range while maintaining the desired channel-to-channel balance. Step sizes are defaulted to 1 dB , but channel sizes can be increased or master sizes decreased by the addition of external resistors. Approximately 80 dB of attenuation and up to 20 dB of gain is possible.
The SSM2160/SSM2161 can operate either single or dual supply, with a total supply voltage range of 8 V to 36 V . An on-chip voltage reference is provided for single-supply applications.

[^219][^220]This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

ELECTRICAL SPECIFICATIONS $\left(V_{S}= \pm 5 \mathrm{~V}, \mathrm{~A}_{V}=0 \mathrm{~dB}, 0 \mathrm{dBu}=0.775 \mathrm{Vrms}, \mathrm{V}_{1 \mathrm{I}}=-10 \mathrm{dBu}, \mathrm{f}_{\mathrm{AUDIO}}=1 \mathrm{kHz}, \mathrm{f}_{\mathrm{CLK}}=250 \mathrm{kHz}\right.$,
$R_{L}=100 \mathrm{k} \Omega,-40^{\circ} \mathrm{C}<\mathrm{T}_{A}<+85^{\circ} \mathrm{C}$, unless otherwise noted. Typical specifications apply at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.)

| Parameter | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| AUDIO PERFORMANCE <br> Noise <br> Headroom Total Harmonic Distortion Plus Noise <br> Channel Separation | $\mathrm{V}_{\mathrm{IN}}=\mathrm{GND}, 20 \mathrm{kHz}$ Bandwidth Clip Point $=1 \% \mathrm{THD}+\mathrm{N}$ 2nd and 3rd Harmonics Only $\begin{aligned} & A_{\mathrm{V}}=0 \mathrm{~dB} \\ & \mathrm{~A}_{\mathrm{V}}=-20 \mathrm{~dB} \\ & \mathrm{~A}_{\mathrm{V}}=0 \mathrm{~dB}, V_{\mathrm{IN}}=+10 \mathrm{dBu} \end{aligned}$ Any Channel to Another |  | $\begin{aligned} & -100 \\ & +10 \\ & \\ & 0.008 \\ & 0.02 \\ & 0.8 \\ & 80 \end{aligned}$ | $\begin{aligned} & \text { TBD } \\ & \\ & \text { TBD } \\ & \text { TBD } \\ & 1.0 \end{aligned}$ | dBu <br> dBu <br> \% <br> \% <br> \% <br> dB |
| ANALOG INPUT Input Offset Voltage Input Impedance |  |  | $\begin{aligned} & 10 \\ & 14 \end{aligned}$ |  | $\begin{aligned} & \mathrm{mV} \\ & \mathrm{k} \Omega \end{aligned}$ |
| GAIN CONTROL ELEMENTS <br> Default Step Size-Master Default Step Size-Channel Gain Error <br> Gain Match Error <br> Mute Attenuation | $\begin{aligned} & \mathrm{A}_{\mathrm{V}} \text { MASTER }=0 \mathrm{~dB} \text { to }-60 \mathrm{~dB} \\ & \mathrm{~A}_{\mathrm{V}} \mathrm{CHANNEL}=0 \mathrm{~dB} \text { to }+20 \mathrm{~dB} \\ & \text { Relative to Same Channel } \\ & \text { A }_{\mathrm{V}} \text { MASTER }=0 \mathrm{~dB} \\ & \text { A }_{\mathrm{V} M A S T E R ~}=-20 \mathrm{~dB} \\ & \text { A }_{\mathrm{V}} \text { MASTER }=-40 \mathrm{~dB} \\ & \text { A }_{\mathrm{V}} \text { MASTER }=-60 \mathrm{~dB} \\ & \text { Channel-to-Channel, Same Level Setting } \\ & \text { A }_{\mathrm{V}} \text { MASTER }=0 \mathrm{~dB} \\ & \text { A }_{\mathrm{V}} \text { MASTER }=-20 \mathrm{~dB} \\ & \mathrm{~A}_{\mathrm{V}} \text { MASTER }=-20 \mathrm{~dB}, \mathrm{~A}_{\mathrm{V}} \mathrm{CH}=+20 \mathrm{~dB} \\ & \text { A }_{\mathrm{V}} \text { MASTER }=-40 \mathrm{~dB} \\ & \text { A }_{\mathrm{V}} \text { MASTER }=-60 \mathrm{~dB} \end{aligned}$ | $\begin{aligned} & \text { TBD } \\ & \text { TBD } \end{aligned}$ | 1.0 <br> 1.0 $-105$ | TBD TBD 0.25 0.25 1 2 0.25 0.25 0.25 1 2 | dB <br> dB <br> dB <br> dB <br> dB <br> dB <br> dB <br> dB <br> dB <br> dB <br> dB <br> dB |
| ANALOG OUTPUT <br> Output Impedance <br> Mute Output Impedance <br> Output Sink Current Minimum Resistive Load Drive Maximum Capacitive Drive Offset Voltage | Channel Muted |  | $\begin{aligned} & \text { TBD } \\ & \text { TBD } \\ & \text { TBD } \\ & \text { TBD } \\ & \text { TBD } \\ & 20 \end{aligned}$ |  | $\Omega$ $\Omega$ <br> mA <br> $\Omega$ <br> pF <br> mV |
| CONTROL SECTION <br> Logic Input LO <br> Logic Input HI <br> Logic Input Current Maximum Clock Frequency Timing Characteristics | Logic LO or HI <br> See Timing Diagram | $\begin{aligned} & 2.0 \\ & 1 \end{aligned}$ | $\begin{aligned} & 1 \\ & 2 \end{aligned}$ | 0.8 | V <br> V <br> $\mu \mathrm{A}$ <br> MHz |
| REFERENCE <br> Output Voltage Output Impedance Load Regulation | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=+10 \mathrm{~V} \text { (Single Supply) } \\ & -10 \mathrm{~mA} \leq \mathrm{I}_{\mathrm{L}} \leq+10 \mathrm{~mA} \end{aligned}$ | 4.9 | $\begin{aligned} & 5.0 \\ & \text { TBD } \\ & 0.1 \end{aligned}$ | 5.1 | $\begin{aligned} & \mathrm{V} \\ & \Omega \\ & \% \end{aligned}$ |
| POWER SUPPLIES <br> Supply Voltage Range <br> Supply Current <br> Power Supply Rejection Ratio | Dual Supply <br> Single Supply <br> Positive <br> Negative <br> Dual Supply | $\begin{aligned} & \pm 4 \\ & +8 \end{aligned}$ | TBD $20$ <br> TBD | $\begin{aligned} & \pm 15 \\ & +30 \\ & \text { TBD } \\ & 30 \end{aligned}$ | V <br> V <br> mA <br> mA <br> dB |

Specifications subject to change without notice.

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| ABSOLUTE MAXIMUM RATINGS ${ }^{1}$ |  |
| :---: | :---: |
| Supply Voltage |  |
| Dual Supply | $\pm 18 \mathrm{~V}$ |
| Single Supply | +36 V |
| Analog Input Voltage | $\pm \mathrm{V}_{\text {S }}$ |
| Logic Input Voltage | $\pm \mathrm{V}_{5}$ |
| Operating Temperature Range | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Storage Temperature | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Junction Temperature ( $\mathrm{T}_{\mathrm{J}}$ ) | $+150^{\circ} \mathrm{C}$ |
| Lead Temperature (Soldering, 60 sec ) | $+300^{\circ} \mathrm{C}$ |

THERMAL CHARACTERISTICS

| Thermal Resistance ${ }^{2}$ |  |
| :---: | :---: |
| 24-Pin Plastic DIP (SSM2160) |  |
| $\theta_{\text {JA }}$ | $\mathrm{TBD}^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\theta_{\text {JC }}$ | TBD ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 24-Pin SOIC (SSM2160) |  |
| $\theta_{\text {JA }}$ | $\mathrm{TBD}^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\theta_{\text {JC }}$ | TBD ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 20-Pin Plastic DIP (SSM2161) |  |
| $\theta_{\text {JA }}$ | $\mathrm{TBD}^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\theta_{\text {JC }}$ | $\mathrm{TBD}^{\circ} \mathrm{C} / \mathrm{W}$ |
| 20-Pin SOIC (SSM2161) |  |
| $\theta_{\text {JA }}$ | TBD ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\theta_{\mathrm{JC}}$ | $\mathrm{TBD}^{\circ} \mathrm{C} / \mathrm{W}$ |

TRANSISTOR COUNT
Number of Transistors

## ESD RATINGS

883 (Human Body) Model . . . . . . . . . . . . . . . . . . . . . TBD kV
EIAJ Model
NOTES
${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2} \theta_{\mathrm{JA}}$ is specified for worst-case conditions, i.e., $\theta_{\mathrm{JA}}$ is specified for device in socket for P-DIP and device soldered in circuit board for SOIC package.

SSM2160 PIN CONFIGURATION

## 24-Lead Plastic DIP and SOIC



## SSM2161 PIN CONFIGURATION



ORDERING GUIDE

| Model | Temperature Range | Package Option ${ }^{\star}$ |
| :--- | :--- | :--- |
| SSM2160N | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-24$ |
| SSM2160R | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-24$ |
| SSM2161N | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-20$ |
| SSM2161R | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-20$ |

${ }^{\star} \mathrm{N}=$ Plastic DIP; $\mathrm{R}=$ SOIC. For outline information see Package Information section.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the SSM2160/SSM2161 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


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SSM2160 POWER SUPPLY CONNECTIONS


## TYPICAL APPLICATION CIRCUIT (DUAL SUPPLY)



Use formula $\mathrm{R}_{\mathrm{M}}=1400 \mathrm{X} /(1 \mathrm{X})$.
** Use formula $R_{C H}=4420 X /(X-1)$, where " $X$ " equals desired step size in $d B$.

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing. Dual Audio

## FEATURES

```
\bullet "Clickless" Bilateral Audio Switching
- Guaranteed "Break-Before-Make" Switching
- Low Distortion
```

$\qquad$

``` 0.003\% Typ
```

- Low Noise ..... $1 \mathrm{nV} / \sqrt{\mathrm{Hz}}$
- Superb OFF-Isolation ..... 120dB Typ
- Low ON-Resistance ..... $60 \Omega$ Typ
- Wide Signal Range:

```\(\mathrm{V}_{\mathrm{s}}= \pm 18 \mathrm{~V}\)10V RMS
```

- Wide Power Supply Range
$\pm 20 \mathrm{~V}$ Max

```
- Available in Dice Form
```


## ORDERING INFORMATION

| PACKAGE |  |  |
| :---: | :---: | :---: |
| PLASTIC | SOL | OPERATING <br> TEMPERATURE |
| 14-PIN | 16-PIN |  |
| SSM2402P | SSM2402S | RANGE |
| SSM2412P | SSM2412S | XIND* |

${ }^{*} \mathrm{XIND}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$

## GENERAL DESCRIPTION

The SSM-2402/2412 are dual analog switches designed specifically for high-performance audio applications. Distortion and noise are negligible over the full audio operating range of 20 Hz to 20 kHz at signal levels of up to $10 \mathrm{~V}_{\text {RMS }}$. The SSM-2402/2412 offer a monolithic integrated alternative to expensive and noisy relays or complex discrete JFET circuits. Unlike conventional general-purpose CMOS switches, the SSM-2402/2412 provide superb fidelity without audio "clicks" during switching.

Conventional TTL or CMOS logic can be used to control the switch state. No external pull-up resistors are needed. A "T" configuration provides superb OFF-isolation and true bilateral operation. The analog inputs and outputs are protected against overload and overvoltage.
An important feature is the guaranteed "break-before-make" for all units, even IC-to-IC. In large systems with multiple switching channels, all separate switching units must open before any switch goes into the ON-state. With the SSM-2402/2412, you can be certain that multiple circuits will all break-before-make.

The SSM-2402/2412 represent a significant step forward in audio switching technology. Distortion and switching noise are significantly reduced in the new SSM-2402/2412 bipolar-JFET switches relative to CMOS switching technology. Based on a
new circuit topology that optimizes audio performance, the SSM-2402/2412 make use of a proprietary bipolar-JFET process with thin-film resistor network capability. Nitride capacitors, which are very area efficient, are used for the proprietary ramp generator that controls the switch resistance transition. Very wide bandwidth amplifiers control the gate-to-source voltage over the full audio operating range for each switch. The ONresistance remains constant with changes in signal amplitude and frequency, thus distortion is very low, less than $0.01 \%$ Max.
The SSM-2402 is the first analog switch truly optimized for highperformance audio applications. For broadcasting and other switching applications which require a faster switching time, we recommend the SSM-2412-adual analog switch with one-third of the switching time of the SSM-2402.

## PIN CONNECTIONS



[^221]FUNCTIONAL DIAGRAM


TIMING DIAGRAM


ABSOLUTE MAXIMUM RATINGS
Operating Temperature Range ....................... $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Operating Supply Voltage Range .................................... $\pm 20 \mathrm{~V}$
Analog Input Voltage Range
Continuous .................................. $\mathrm{V}-+3.5 \mathrm{~V} \leq \mathrm{V}_{\mathrm{A}} \leq \mathrm{V}+-3.5 \mathrm{~V}$
Maximum Current Through Switch ................................. 20mA
Logic Input Voltage Range ........................... V+ Supply to -2V
V+ Supply to Ground ....................................................... +36V
V-Supply to Ground ......................................................... -20V
$V_{A}$ to V-Supply ............................................................... +36 V

| PACKAGE TYPE | $\theta_{\text {JA }}$ (NOTE 1) | $\boldsymbol{\theta}_{\mathrm{JC}}$ | UNITS |
| :--- | :---: | :---: | :---: |
| 14-Pin Plastic DIP (P) | 76 | 33 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 16-Pin SOL (S) | 92 | 27 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTE:

1. $\Theta_{j A}$ is specified for worst case mounting conditions, i.e., $\Theta_{\mid A}$ is specified for device in socket for P-DIP package; $\Theta_{j A}$ is specified for device soldered to printed circuit board for SOL package.

ELECTRICAL CHARACTERISTICS at $V_{S}= \pm 18 \mathrm{~V}, R_{L}=$ OPEN, and $-40^{\circ} \mathrm{C} \leq T_{A} \leq+85^{\circ} \mathrm{C}$, unless otherwise noted.
All specifications, tables, graphs, and application data apply to both the SSM-2402 and SSM-2412, unless otherwise noted.

| PARAMETER | SYMBOL |
| :--- | :--- | :--- | :--- | :--- |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{S}= \pm 18 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=$ OPEN, and $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$, unless otherwise noted. Continued


## NOTES:

1. " $V_{11}$ " is the Logic Control Input.
2. Current tested at $\mathrm{V}_{\mathrm{IN}}=\mathrm{OV}$. This is the worst case condition.
3. Guaranteed by $\mathrm{R}_{\mathrm{ON}}$ test condition.
4. Turn-ONTime is measured from the time the logic input reaches the $50 \%$ point to the time the output reaches $50 \%$ of the final value.
5. Turn-OFF time is measured from the time the logic input reaches the $50 \%$ point to the time the output reaches $50 \%$ of the initial value.
6. Switch is guaranteed by design to provide break-before-make operation.
7. THD guaranteed by design and dynamic $\mathrm{R}_{\mathrm{ON}}$ testing.

## FEATURES

## "Clickless" Bilateral Audio Switching

Four SPST Switches in a 20-Pin Package Ultralow THD+N: 0.0008\% @ 1 kHz (2 V rms, $\mathrm{R}_{\mathrm{L}}=100 \mathrm{k} \Omega$ )
Low Charge Injection: $\mathbf{3 5}$ pC typ
High OFF Isolation: - 100 dB typ ( $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ @ 1 kHz )
Low Crosstalk: -94 dB typ ( $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ @ 1 kHz )
Low ON Resistance: $\mathbf{2 8} \boldsymbol{\Omega}$ typ
Low Supply Current: $\mathbf{9 0 0} \boldsymbol{\mu A}$ typ
Single or Dual Supply Operation: +11 V to +24 V or $\pm 5.5 \mathrm{~V}$ to $\pm 12 \mathrm{~V}$
Guaranteed Break-Before-Make
TTL and CMOS Compatible Logic Inputs
Low Cost-Per-Switch

## GENERAL DESCRIPTION

The SSM-2404 integrates four SPST analog switches in a single 20-pin package. Developed specifically for high performance audio applications, distortion and noise are negligible over the full operating range of 20 Hz to 20 kHz . With very low charge injection of 35 pC , "clickless" audio switching is possible, even under the most demanding conditions.
Switch control is realized by conventional TTL or CMOS logic. Guaranteed "break-before-make" operation assures that all switches in a large system will open before any switch reaches the ON state.

Single or dual supply operation is possible. Additional features include -100 dB OFF isolation, -94 dB crosstalk and $28 \Omega$ ON resistance. Optional current-mode switching permits an extended signal-handling range. Although optimized for large load impedances, the SSM-2404 maintains good audio performance even under low load impedance conditions.

BLOCK DIAGRAM OF ONE SWITCH CHANNEL


PIN CONNECTIONS
Epoxy Mini-DIP (P-Suffix) and SOIC (S-Suffix)



| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| AUDIO PERFORMANCE |  |  |  |  |  |  |
| Total Harmonic Distortion Plus Noise | THD +N | @ 1 kHz , with 80 kHz Filter, |  |  |  |  |
|  |  | $\mathrm{R}_{\mathrm{L}}=100 \mathrm{k} \Omega, \mathrm{V}_{\mathrm{IN}}=2 \mathrm{~V} \mathrm{rms}$ |  | 0.0008 |  |  |
| Spectral Noise Density | $\mathrm{e}_{\mathrm{n}}$ | 20 Hz to 20 kHz |  | 0.8 |  | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| Wideband Noise Density | $\mathrm{e}_{\mathrm{n}} \mathrm{p}$-p | 20 Hz to 20 kHz |  | 0.6 |  | $\mu \mathrm{V}$ p-p |
| ANALOG SIGNAL SECTION |  |  |  |  |  |  |
| Analog Voltage Range | $\mathrm{V}_{\text {A }}$ | $\mathrm{V}_{\text {INH }}=2.4 \mathrm{~V}, \mathrm{I}_{\mathrm{A}}= \pm 2 \mathrm{~mA}$ |  | $\pm 12$ |  | V |
| Analog Current Range | $\mathrm{I}_{\text {A }}$ | $\mathrm{V}_{\text {INH }}=2.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{A}}=0 \mathrm{~V}$ |  | $\pm 10$ |  | mA |
| ON Resistance | $\mathrm{R}_{\mathrm{ON}}$ | $\mathrm{I}_{\mathrm{A}}= \pm 10 \mathrm{~mA}, \mathrm{~V}_{\mathrm{A}}= \pm 10 \mathrm{Vdc}$ |  | 28 | 45 | $\Omega$ |
| $\mathrm{R}_{\text {ON }}$ Matching | $\mathrm{R}_{\text {ON }}$ Match | $\mathrm{I}_{\mathrm{A}}= \pm 10 \mathrm{~mA}, \mathrm{~V}_{\mathrm{A}}=0 \mathrm{~V}$ |  | 1 |  | \% |
| ON Leakage Current | $\mathrm{I}_{\text {(ON) }}$ | $\mathrm{V}_{\mathrm{A}}= \pm 10 \mathrm{~V}$ | -20 | 0.1 | +20 | nA |
| OFF Leakage Current | $\mathrm{I}_{\text {S(OFF) }}$ | $\mathrm{V}_{\mathrm{A}}= \pm 10 \mathrm{~V}$ | -20 | 0.1 | +20 | nA |
| Charge Injection | Q |  |  | 35 |  | pC |
| ON-State Input Capacitance | $\mathrm{C}_{\mathrm{ON}}$ | $\mathrm{V}_{\mathrm{A}}=5 \mathrm{~V} \mathrm{rms}$ |  | 31 |  | pF |
| OFF-State Input Capacitance | $\mathrm{C}_{\text {OFF }}$ | $\mathrm{V}_{\mathrm{A}}=5 \mathrm{~V} \mathrm{rms}$ |  | 17 |  | pF |
| OFF Isolation | $\mathrm{I}_{\text {SO(OFF) }}$ | $\mathrm{V}_{\mathrm{A}}=50 \mathrm{mV} \mathrm{rms}, \mathrm{f}=1 \mathrm{kHz}, \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ |  | -100 |  | dB |
| Channel-to-Channel Crosstalk | $\mathrm{C}_{\mathrm{T}}$ | $\mathrm{V}_{\mathrm{A}}=50 \mathrm{mV} \mathrm{rms}, \mathrm{f}=1 \mathrm{kHz}, \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ |  | -94 |  | dB |
| CONTROL SECTION |  |  |  |  |  |  |
| Digital Input High | $\mathrm{V}_{\text {INH }}$ | DGND $=0 \mathrm{~V}$ | 2.4 |  | $\mathrm{V}_{\mathbf{S}}$ | V |
| Digital Input Low | $\mathrm{V}_{\text {INL }}$ | DGND $=0 \mathrm{~V}$ | 0 |  | 0.8 | V |
| Turn-On Time ${ }^{1}$ | $\mathrm{t}_{\mathrm{ON}}$ | See Test Circuit |  | 8 | 50 | ms |
| Turn-Off Time ${ }^{2}$ | $\mathrm{t}_{\text {OFF }}$ | See Test Circuit |  | 5 | 30 | ms |
| Break-Before-Make Time Delay $\mathrm{t}_{\text {ON }} \mathrm{t}_{\text {OFF }}$  3 3 <br> Logic Input Current     |  |  |  |  |  |  |
|  |  |  |  |  |  |  |
| Logic HI |  | $\mathrm{V}_{\text {INH }}=2.4 \mathrm{~V}$ | -1000 | 1.3 | +1000 | nA |
| Logic LO |  | $\mathrm{V}_{\text {INL }}=0.8 \mathrm{~V}$ | -1000 | 1.0 | +1000 | nA |
| POWER SUPPLY |  |  |  |  |  |  |
| Supply Voltage Range | $\mathrm{V}_{\mathrm{S}}$ | Single Supply | +11 |  | +24 | V |
|  |  | Dual Supply | $\pm 5.5$ |  | $\pm 12$ | V |
| Positive Supply Current | $\mathrm{I}_{\text {SY }+}$ | All Channels On |  | 0.9 | 5 | mA |
| Negative Supply Current | $\mathrm{I}_{\text {SY- }}$ | All Channels On | -1.5 | -0.6 |  | mA |
| Ground Current |  | All Channels On | -2.0 | -0.3 |  | mA |

NOTES
${ }^{1}$ Turn-on time is measured from the time the logic input reaches the $50 \%$ point to the time the output reaches $50 \%$ of the final value.
${ }^{2}$ Turn-off time is measured from the time the logic input reaches the $50 \%$ point to the time the output reaches $50 \%$ of the initial value.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS

Supply Voltage
Single Supply . . . . . . . . . . . . . . . . . . . . . . . . . . + 27 V
Dual Supply . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 13.5$ V
Analog Input Voltage ( $\mathrm{V}_{\mathrm{A}}$ ) . . . . . . . . . . . . . . . . . . . . . . V $\mathrm{V}_{\text {S }}$
Logic Input Voltage ( $\mathrm{V}_{\text {INL/INH }}$ ) . . . . . . . . . . . . . . . . . . . V $\mathrm{V}_{\mathrm{S}}$
Maximum Current Through Any Switch . . . . . . . . . . 20 mA
Operating Temperature Range . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Junction Temperature ( $\mathrm{T}_{\mathrm{J}}$ ) . . . . . . . . . . . . . . . . . . . $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 60 sec ) . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Thermal Resistance ${ }^{1}$
20-Pin Plastic DIP (P): $\theta_{\mathrm{JA}}=74, \theta_{\mathrm{JC}}=32 \ldots \ldots{ }^{\circ} \mathrm{C} / \mathrm{W}$
$20-\operatorname{Pin} \operatorname{SOIC}(S): \theta_{J A}=90, \theta_{\mathrm{JC}}=27 \ldots . . . .{ }^{\circ} \mathrm{C} / \mathrm{W}$

[^222]
## ORDERING GUIDE

| Model | Operating <br> Temperature <br> Range | Package | Package <br> Option |
| :--- | :--- | :--- | :--- |
| SSM2404P | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 20-Pin Plastic DIP | N-20 <br> R-20 |

* $\mathrm{N}=$ Plastic DIP, $\mathrm{R}=$ SOIC. For outline information see Package Information section.


Test Circuit for $t_{\text {ON }} / t_{\text {OFF }}$ Timing Specification, $t_{\text {ON }} / t_{\text {OFF }}$ Switching Response, and ON/OFF Transition Photos


Figure 1. $T H D+N$ vs. Frequency $\left(V_{s}= \pm 12 V\right.$, $V_{A}=2 \mathrm{~V}$ rms, with 80 kHz Filter)


Figure 2. Headroom $\left(V_{S}= \pm 12 V, f=1 \mathrm{kHz}\right.$, with 80 kHz Filter)


Figure 3. $T H D+N$ vs. Load $\left(V_{S}= \pm 12 V, V_{A}=2 \mathrm{Vrms}\right.$, $f=1 \mathrm{kHz}$, with 80 kHz Filter)


Figure 4. $T H D+N$ vs. Supply Voltage ( $V_{A}=2 \mathrm{~V} r m s$, $f=1 \mathrm{kHz}, R_{L}=100 \mathrm{k} \Omega$, with 80 kHz Filter)


Figure 5. Frequency Response ( $V_{S}= \pm 12 \mathrm{~V}$, $V_{\mathrm{A}}=1 \mathrm{Vrms}, R_{L}=100 \mathrm{k} \Omega$ )


Figure 6. SSM-2404 Spectral Noise Density $E_{n}$ [5 Devices (20 Switches) Chained Together]


Figure 7. Square Wave Response $\left(T_{A}=+25^{\circ} \mathrm{C}\right.$, $\left.V_{S}= \pm 12 \mathrm{~V}, R_{L}=100 \mathrm{k} \Omega, f=20 \mathrm{kHz}\right)$


Figure 8. Output Voltage Swing vs. Load Resistance


Figure 9. Output Voltage Swing vs. Supply Voltage


Figure 10. OFF-Isolation vs. Frequency


Figure 11. Channel-to-Channel Crosstalk vs. Frequency (Worst-Case Conditions, as Measured Between Switches 1 and 4, or 2 and 3)


Figure 12. ON Resistance vs. Analog Voltage


Figure 13. Overvoltage Characteristics


Figure 14. Leakage Current vs. Analog Voltage


Figure 15. Switching Time vs. Temperature


Figure 16. Supply Current vs. Temperature


Figure 17. $t_{\text {ON }} / t_{\text {OFF }}$ Switching Response


Figure 18. Switch OFF-to-ON Transition $\left(R_{L}=5 \mathrm{k} \Omega\right)$


Figure 19. Switch ON-to-OFF Transition $\left(R_{L}=5 \mathrm{k} \Omega\right)$

## APPLICATIONS INFORMATION

The SSM-2404 integrates four analog CMOS switches with guaranteed "break-before-make" operation to provide high quality audio switching. Each switch has complementary N-channel and P-channel MOSFETs to allow the analog input voltage range to include the positive and negative rails and improve linearity. In addition, the topology permits fully bilateral switching. When using the SSM-2404 there is full flexibility in configuring the switches. For example, they can be used individually as shown in Figure 20, or as a double-pole, double-throw (DPDT) switch, which is explained later. The SSM-2404 can also be configured
as a $4: 1$ multiplexer, or by using additional packages, as $8: 1$ or 16:1 and up. The break-before-make feature is guaranteed from part to part allowing such multiple-package applications.
As Figure 20 shows, the SSM-2404 is easy to use, and no additional devices are needed. The load resistors are recommended for improved OFF-isolation and charge injection. The ON resistance of the switch is only $28 \Omega$ typically, which causes very little signal attenuation even with a load resistor.


Figure 20. Basic Circuit Configuration

## OPTIMIZING PERFORMANCE

As the performance curves show, the switch is optimized for high impedance loads. The distortion performance is at its best when the switch has a load impedance of $100 \mathrm{k} \Omega$ or greater as shown in Figure 1. However, even at lower values of load resistances, the 1 kHz distortion performance is still excellent, $0.006 \%$ for a $10 \mathrm{k} \Omega$ load. The main trade-off with THD is OFF-isolation and crosstalk. This is shown in Figures 10 and 11, again with two different load conditions. As these graphs show, the $10 \mathrm{k} \Omega$ load yields approximately a 16 dB improvement in both characteristics.
Thus, the optimum operating point depends on the most critical parameters. When THD is critical then high load impedances should be used; however, when crosstalk and OFF-isolation are critical, lower impedances on the order of $10 \mathrm{k} \Omega$ should be used. An additional benefit of using the smaller load resistor is that any charge injected onto the output will be shunted to ground through the resistor. If improved OFF-isolation is needed, the SSM-2402 dual audio switch should be considered with its excellent 120 dB OFF-isolation at 20 kHz .
It is important that all of the AGND pins be connected to the system analog ground. These pins isolate the input and output of each switch. Without connecting these pins, the OFFisolation will degrade significantly.

## DETAILED SWITCH OPERATION

A simplified circuit schematic with the functional sections is shown in Figure 21. The TTL interface has an internally regulated 5 V to ensure TTL logic levels regardless of the supply voltage. The logic threshold is with respect to the DGND pin, which can be offset. For example, if DGND is connected to the negative supply, then the SSM-2404 will operate with negative rail logic. The interface shifts the control logic down to the negative supply and inverts it to drive N1.


Figure 21. Simplified Schematic

N 1 in combination with Cl and the 100 nA current source provides the break-before-make operation of the switch. When the switch is on, Nl is off and Cl is charged up to the positive rail. However, when the SW CONTROL is turned off, then the gate of N1 is pulled high. This turns N1 on, providing a low impedance path to quickly discharge Cl to the negative rail, which quickly "breaks" the switch. On the other hand, when the SW CONTROL goes high again, the gate of N1 is pulled low, turning it off. This leaves Cl to be slowly charged up to the positive rail by the 100 nA current source. The difference in the discharge and charging times ensures break-before-make operation, even from device to device.

The voltage on Cl is inverted by Pl to drive the ramp generator differential pair, consisting of P2, P3 and N2, N3. This differential pair steers the 100 nA of tail current to either charge or discharge C2. As discussed above, when the switch is on, C 1 is charged up to the positive rail. P1 inverts this, putting a low voltage equivalent to the negative supply on the gate of P2. The BIAS voltage is approximately equal to the midpoint of the two supply voltages. Thus, when P2 is pulled down, it is turned on and P3 is off. All of the 100 nA flows through N 2 and is mirrored by N3. Thus, the 100 nA discharges C2 through N3. When C2 is pulled low, the inverter turns N4 on by pulling its gate high, and the second inverter turns P4 on. To turn the switch off the gate of P 2 is pulled above the BIAS so that all 100 nA charges C2 through P3. This is then inverted to turn off N4 and P4.
The internal ramp has rise and fall times on the order of a few milliseconds which is sped-up by the inverters. As the gate
voltages of N4 and P4 are changing, the ON resistance of each switch is ramping from its OFF state to $28 \Omega$ and vice versa. The actual rise and fall times are shown in Figures 18 and 19 for a $5 \mathrm{k} \Omega$ load. These times are significantly slower than typical switches, minimizing the SSM-2404's charge injection and giving it "clickless" performance.

## DOUBLE-POLE DOUBLE-THROW SWITCH

The SSM-2404 is ideal as a one-chip solution for a stereo switch. The schematic in Figure 22 shows the typical configuration. This circuit will select one of two stereo sources, channel A or B. The switch controls for the left and right input of each channel are tied together so that both will be turned on or off simultaneously. An inverter is inserted between the channel A and B controls so that only one logic signal is needed. The outputs can be configured many different ways, such as an inverting or noninverting amplifier stage, and the $10 \mathrm{k} \Omega$ load resistors are added to improve the OFF-isolation. The performance of this stereo switch is equivalent to each individual switch, yielding a high quality audio switch that is virtually transparent to the signal.


Figure 22. Double-Pole, Double-Throw Stereo Switch

## VIRTUAL GROUND SWITCHING

The SSM- 2404 was built on a CMOS process with a 24 V operating limit for the total supply voltage across the part. This leads to a corresponding limit on the analog voltage range. However, to achieve larger signal swings, the SSM-2404 should be configured in the virtual ground mode. As shown in Figure 23, the output of the SSM-2404 is connected to the inverting input of an amplifier. Since the noninverting input is grounded, the SSM-2404 will also be biased at ground, and large voltage swings on the circuit's input will not significantly change the voltage on the switch. The only limitation is that the current through the switch needs to be less than $\pm 10 \mathrm{~mA}$, and the voltage range is limited only by the op amp and its supply voltages.

The circuit was tested with an SSM-2131 high slew rate audio amplifier and the results are shown in Figures 24 and 25. This configuration yields excellent THD performance that is primarily determined by the amplifier. Also, the headroom is now $+24 \mathrm{dBu}(0 \mathrm{dBu}=0.775 \mathrm{~V} \mathrm{rms})$, which is due to the amplifier's output voltage swing. Thus, even though the SSM-2404 has $\mathrm{a} \pm 12 \mathrm{~V}$ limitation on its supplies, it can be used in systems with much higher voltage ranges. For example, the double-pole double-throw switch from Figure 22 can be reconfigured in the virtual ground mode to allow higher voltage swings, as shown in Figure 26. This application realizes the excellent performance of Figures 24 and 25 while providing a low cost switching solution.


Figure 23. Virtual Ground Switching


Figure 24. Virtual Ground Switch THD $+N$ vs. Frequency ( $V_{S}= \pm 12 \mathrm{~V}, V_{\mathrm{A}}=2 \mathrm{~V} \mathrm{rms}$, with 80 kHz Filter)


Figure 25. Virtual Ground Switch Headroom $\left(V_{s}= \pm 12 V\right.$ for SSM-2404; $V_{S}= \pm 18 \mathrm{~V}$ for Op Amp, $f=1 \mathrm{kHz}$, with 80 kHz Filter)


Figure 26. Double-Pole, Double-Throw Stereo Switch Using Virtual Ground Operation

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## Selection Guides-Interface Products

Line Drivers/Receivers

| Model | Power Supply | No. of Drivers | No. of Receivers | Data Rate kB/S | External Capacitors | Low Power Shutdown SD | TTL ThreeState $\overline{\mathbf{E N}}$ | No. of Pins | Package Options ${ }^{1}$ | Temperature Ranges ${ }^{2}$ | Page |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ADM202 | +5 V | 2 (232) | 2 (232) | 120 | 4-0.1 $\mu \mathrm{F}$ | No | No | 16 | $\mathbf{N}, \mathbf{R}$ | C | 15-26 |
| ADM203 | +5V | 2 (232) | 2 (232) | 120 | None | No | No | 20 | N | C | 15-26 |
| ADM205 | +5V | 5 (232) | 5 (232) | 120 | None | Yes | Yes | 24 | N | I | 15-30 |
| ADM206 | $+5 \mathrm{~V}$ | 4 (232) | 3 (232) | 120 | 4-0.1 $\mu \mathrm{F}$ | Yes | Yes | 24 | N, R, RS | I | 15-30 |
| ADM207 | $+5 \mathrm{~V}$ | 5 (232) | 3 (232) | 120 | 4-0.1 $\mu \mathrm{F}$ | No | No | 24 | N, R, RS | I | 15-30 |
| ADM208 | $+5 \mathrm{~V}$ | 4 (232) | 4 (232) | 120 | 4-0.1 $\mu \mathrm{F}$ | No | No | 24 | N, R, RS | I | 15-30 |
| ADM209 | +5V, +12 V | 3 (232) | 5 (232) | 120 | 2-0.1 $\mu \mathrm{F}$ | No | Yes | 24 | N, R, RS | I | 15-30 |
| ADM211 | $+5 \mathrm{~V}$ | 4 (232) | 5 (232) | 120 | 4-0.1 $\mu \mathrm{F}$ | Yes | Yes | 28 | R, RS | I | 15-30 |
| ADM213 | +5 V | 4 (232) | 5 (232) | 120 | 4-0.1 $\mu \mathrm{F}$ | Yes ( $\overline{\mathbf{S D}}$ ) | Yes (EN) | 28 | R, RS | I | 15-30 |
| ADM222 | +5 V | 2 (232) | 2 (232) | 200 | 4-0.1 $\mu \mathrm{F}$ | Yes (SD) | No | 18 | N, R | I | 15-40 |
| ADM223 | +5V | 4 (232) | 5 (232) | 120 | 4-1.0 $\mu \mathrm{F}$ | Yes (SD) | Yes (EN) | 28 | R, RS | I | 15-47 |
| ADM230L | +5V | 5 (232) | 0 | 120 | 4-1.0 $\mu \mathrm{F}$ | Yes | No | 20 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I | 15-47 |
| ADM231L | +5 V, +12 V | 2 (232) | 2 (232) | 120 | 2-1.0 $\mu \mathrm{F}$ | No | No | 14 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I | 15-47 |
| ADM232A | $+5 \mathrm{~V}$ | 2 (232) | 2 (232) | 200 | 4-0.1 $\mu \mathrm{F}$ | No | No | 16 | $\mathbf{N}, \mathbf{R}$ | I | 15-40 |
| ADM232L | +5 V | 2 (232) | 2 (232) | 120 | 4-1.0 $\mu \mathrm{F}$ | No | No | 16 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I | 15-47 |
| ADM233L | +5 V | 2 (232) | 2 (232) | 120 | None | No | No | 20 | N | C, I | 15-47 |
| ADM234L | +5 V | 4 (232) | 0 | 120 | 4-1.0 $\mu \mathrm{F}$ | No | No | 16 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I | 15-47 |
| ADM235L | +5 V | 5 (232) | 5 (232) | 120 | None | Yes | Yes | 24 | $\mathbf{N}, \mathbf{Q}$ | C, I | 15-47 |
| ADM236L | +5 V | 4 (232) | 3 (232) | 120 | 4-1.0 $\mu \mathrm{F}$ | Yes | Yes | 24 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I | 15-47 |
| ADM237L | +5V | 5 (232) | 3 (232) | 120 | 4-1.0 $\mu \mathrm{F}$ | No | No | 24 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I | 15-47 |
| ADM238L | $+5 \mathrm{~V}$ | 4 (232) | 4 (232) | 120 | 4-1.0 $\mu \mathrm{F}$ | No | No | 24 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I | 15-47 |
| ADM239L | +5 V, +12 V | 3 (232) | 5 (232) | 120 | 2-1.0 $\mu \mathrm{F}$ | No | Yes | 24 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I | 15-47 |
| ADM241L | $+5 \mathrm{~V}$ | 4 (232) | 5 (232) | 120 | 4-1.0 $\mu \mathrm{F}$ | Yes | Yes | 28 | $\mathbf{R , R S}$ | C, I | 15-47 |
| ADM242 | $+5 \mathrm{~V}$ | 2 (232) | 2 (232) | 200 | $4-0.1 \mu \mathrm{~F}$ | Yes ( $\overline{\mathbf{S D}}$ ) | Yes | 18 | N, R | I | 15-40 |
| ADM5170 | $+10 \mathrm{~V},-10 \mathrm{~V}$ | 8 (232/423) | 0 | 116 | None | No | Yes | 28 | $\mathbf{N}, \mathbf{P}$ | C, I | 15-91 |
| ADM5180 | +5V | 0 | 8 (232/423) | 200 | None | No | No | 28 | $\mathbf{N}, \mathbf{P}$ | C, I | 15-95 |
| ADM485 | +5 V | 1 (485) | 1 (485) | 5000 | None | No | No | 8 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I | 15-57 |
| ADM1485 | +5 V | 1 (485) | 1 (485) | 30000 | None | No | No | 8 | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I | 15-84 |
| AD7306 | +5 V | 2 (232) | 1 (232) | 100 | 4-0.1 $\mu \mathrm{F}$ | No | No | 24 | R | C | 15-18 |
|  |  | 1 (422) | 1 (232/422) | 5000 |  |  |  |  |  |  |  |

[^223]
## Clock Recovery Circuits

|  |  | Package | Temp |  |  |  |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Model | Description | Frequency | Options $^{1}$ | Ranges $^{2}$ | Page | Comments |
| AD800-45 | Clock Recovery and Data Retiming Phase Locked Loop | 44.736 MHz DS-3 | Q | I | 15-7 | 5 V Supply, 10K ECL Compatible |
| AD800-52 | Clock Recovery and Data Retiming Phase Locked Loop | 51.84 MHz STS-1 | R | I | 15-7 | 5 V Supply, 10K ECL Compatible |
| AD800-155 | Clock Recovery and Data Retiming Phase Locked Loop | 155.52 MHz STS-3 or STM-1 | R | C | 15-7 | 5 V Supply, 10K ECL Compatible |



 ${ }^{2}$ Temperature Ranges: $\mathrm{C}=$ Commercial, $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C} ; \mathrm{I}=$ Industrial, $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ (Some older products $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ); $\mathrm{M}=\mathrm{Military}$, $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. If a device has military grade offerings, the M temperature designator will be followed by: / to indicate $883 \mathrm{~B},{ }_{\mathrm{J}}$ for JAN, ${ }_{\mathrm{D}}$ for SMD, and ${ }_{\mathrm{s}}$ for space level.
Boldface Type: Data sheet information in this volume.

Clock Recovery and Data Retiming Phase-Locked Loop AD800/AD802*

## FEATURES

Standard Products
44.736 Mbps - DS-3
51.84 Mbps - STS-1
155.52 Mbps - STS-3 or STM-1

Accepts NRZ Data, No Preamble Required
Recovered Clock and Retimed Data Outputs
Phase-Locked Loop Type Clock Recovery - No Crystal Required
Random Jitter: $\mathbf{2 0}^{\circ}$ Peak-to-Peak
Pattern Jitter: Virtually Eliminated
10KH ECL Compatible
Single Supply Operation: -5.2 V or +5 V
Wide Operating Temperature Range: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$

## PRODUCT DESCRIPTION

The AD800 and AD802 employ a second order phase-locked loop architecture to perform clock recovery and data retiming on Non-Return to Zero, NRZ, data. This architecture is capable of supporting data rates between 20 Mbps and 160 Mbps . The products described here have been defined to work with standard telecommunications bit rates. 45 Mbps DS-3 and 52 Mbps STS-1 are supported by the AD800-45 and AD800-52 respectively. 155 Mbps STS-3 or STM-1 are supported by the AD802-155.

Unlike other PLL-based clock recovery circuits, these devices do not require a preamble or an external VCXO to lock onto input data. The circuit acquires frequency and phase lock using two control loops. The frequency acquisition control loop initially acquires the clock frequency of the input data. The phaselock loop then acquires the phase of the input data, and ensures that the phase of the output signals track changes in the phase of the input data. The loop damping of the circuit is dependent on the value of a user selected capacitor; this defines jitter peaking performance and impacts acquisition time. The devices exhibit 0.08 dB jitter peaking, and acquire lock on random or scrambled data within $4 \times 10^{5}$ bit periods when using a damping factor of 5 .
During the process of acquisition the frequency detector provides a Frequency Acquisition (FRAC) signal which indicates that the device has not yet locked onto the input data. This signal is a series of pulses which occur at the points of cycle slip between the input data and the synthesized clock signal. Once the circuit has acquired frequency lock no pulses occur at the FRAC output.

[^224]FUNCTIONAL BLOCK DIAGRAM


The inclusion of a precisely trimmed VCO in the device eliminates the need for external components for setting center frequency, and the need for trimming of those components. The VCO provides a clock output within $\pm 20 \%$ of the device center frequency in the absence of input data.

The AD800 and AD802 exhibit virtually no pattern jitter, due to the performance of the patented phase detector. Total loop jitter is $20^{\circ}$ peak-to-peak. Jitter bandwidth is dictated by mask programmable fractional loop bandwidth. The AD800, used for data rates $<90 \mathrm{Mbps}$, has been designed with a nominal loop bandwidth of $0.1 \%$ of the center frequency. The AD802, used for data rates in excess of 90 Mbps , has a loop bandwidth of $0.08 \%$ of center frequency.
All of the devices operate with a single +5 V or -5.2 V supply.

#  <br> Factor $=5$, unless otherwise noted) 

| Parameter ${ }^{1}$ | Condition | AD800-45BQ |  |  | AD800-52BR |  |  | AD802-155KR/BR |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| NOMINAL CENTER FREQUENCY |  | 44.736 |  |  | 51.84 |  |  | 155.52 |  |  | MHz |
| OPERATING TEMPERATURE RANGE ( $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ ) | K Grade <br> B Grade | -40 |  | 85 | -40 |  | 85 | $\left.\right\|_{0} ^{0}$ |  | $\begin{aligned} & 70 \\ & 85 \end{aligned}$ | $\begin{aligned} & { }^{\circ} \mathrm{C} \\ & { }^{\circ} \mathrm{C} \end{aligned}$ |
| TRACKING RANGE |  | 43 |  | 45.5 | 49 |  | 53 | 155 |  | 156 | Mbps |
| CAPTURE RANGE |  | 43 |  | 45.5 | 49 |  | 53 | 155 |  | 156 | Mbps |
| STATIC PHASE ERROR | $\begin{aligned} & \rho=1, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \\ & \mathrm{~V}_{\mathrm{EE}}=-5.2 \mathrm{~V} \\ & \rho=1 \end{aligned}$ |  |  |  |  |  | $\begin{aligned} & 10 \\ & 11.5 \end{aligned}$ | $\begin{aligned} & 14 \\ & 18 \end{aligned}$ |  | $\begin{aligned} & 30 \\ & 37 \end{aligned}$ | Degrees Degrees |
| RECOVERED CLOCK SKEW | $\mathrm{t}_{\text {RCS }}$ (Figure 1) | 0.2 | 0.6 | 1 | 0.2 | 0.6 | 1 | 0.2 | 0.8 | 1 | ns |
| SETUP TIME | $\mathrm{t}_{\text {SU }}$ (Figure 1) |  |  |  |  |  |  | 2.06 | 2.37 |  | ns |
| TRANSITIONLESS DATA RUN |  |  |  | 240 |  |  | 240 |  |  | 240 | Bit Periods |
| OUTPUT JITTER | $\begin{aligned} & \rho=1 \\ & 2^{7}-1 \text { PRN Sequence } \\ & 2^{23}-1 \text { PRN Sequence } \end{aligned}$ |  | $\begin{aligned} & 2 \\ & 2.5 \\ & 2.5 \end{aligned}$ | $\begin{aligned} & 4.7 \\ & 4.7 \end{aligned}$ |  | $\begin{aligned} & 2 \\ & 2.5 \\ & 2.5 \end{aligned}$ | $\begin{aligned} & 4.7 \\ & 4.7 \end{aligned}$ |  | $\begin{aligned} & 3.5 \\ & 5.4 \\ & 5.4 \end{aligned}$ | $\begin{aligned} & 9.7 \\ & 9.7 \end{aligned}$ | Degrees rms Degrees rms Degrees rms |
| JITTER TOLERANCE | $\begin{aligned} & \mathrm{f}=10 \mathrm{~Hz} \\ & \mathrm{f}=2.3 \mathrm{kHz} \\ & \mathrm{f}=30 \mathrm{kHz} \\ & \mathrm{f}=1 \mathrm{MHz} \\ & \mathrm{f}=30 \mathrm{~Hz} \\ & \mathrm{f}=300 \mathrm{~Hz} \\ & \mathrm{f}=2 \mathrm{kHz} \\ & \mathrm{f}=20 \mathrm{kHz} \\ & \mathrm{f}=6.5 \mathrm{kHz} \\ & \mathrm{f}=65 \mathrm{kHz} \end{aligned}$ | $\begin{aligned} & 6.5 \\ & 0.47 \\ & 0.47 \end{aligned}$ | 2,500 |  | $\begin{aligned} & 830 \\ & 83 \\ & 7.4 \\ & 0.47 \end{aligned}$ | $2,500$ |  | $\begin{array}{\|c}  \\ \\ \\ \\ 2.0 \\ 0.26 \end{array}$ | $\begin{gathered} 3,000 \\ \\ \\ \\ 7.6 \\ 0.9 \end{gathered}$ |  | Unit Intervals Unit Intervals Unit Intervals Unit Intervals Unit Intervals Unit Intervals Unit Intervals Unit Intervals Unit Intervals Unit Intervals |
| JITTER TRANSFER <br> Damping Factor Capacitor, $\mathrm{C}_{\mathrm{D}}$ $\zeta=1$, Nominal <br> $\zeta=5$, Nominal <br> $\zeta=10$, Nominal <br> Peaking <br> $\zeta=1$, Nominal <br> $\zeta=5$, Nominal <br> $\zeta=10$, Nominal <br> Bandwidth | $\begin{aligned} & \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{~V}_{\mathrm{EE}}=-5.2 \mathrm{~V} \\ & \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{~V}_{\mathrm{EE}}=-5.2 \mathrm{~V} \\ & \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{~V}_{\mathrm{EE}}=-5.2 \mathrm{~V} \end{aligned}$ |  | 8.2 <br> 0.22 <br> 0.82 <br> 2 <br> 0.08 <br> 0.02 <br> 45 |  |  | $\begin{aligned} & 6.8 \\ & 0.15 \\ & 0.68 \\ & \\ & 2 \\ & 0.08 \\ & 0.02 \\ & 52 \end{aligned}$ | ' |  | 2.2 <br> 0.047 <br> 0.22 <br> 2 <br> 0.08 <br> 0.02 <br> 130 |  | nF $\mu \mathrm{F}$ $\mu \mathrm{F}$ dB dB dB kHz |
| ACQUISITION TIME $\begin{aligned} & \rho=1 / 2 \\ & T_{A}=+25^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{EE}}=-5.2 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & \zeta=1 \\ & \zeta=5 \\ & \zeta=10 \end{aligned}$ |  | $\begin{aligned} & 1 \times 10^{4} \\ & 3 \times 10^{5} \\ & 8 \times 10^{5} \end{aligned}$ | $8 \times 10^{5}$ |  | $\begin{aligned} & 1 \times 10^{4} \\ & 3 \times 10^{5} \\ & 8 \times 10^{5} \end{aligned}$ | $8 \times 10^{5}$ |  | $\begin{aligned} & 1.5 \times 10^{4} \\ & 4 \times 10^{5} \\ & 1.4 \times 10^{6} \end{aligned}$ | $8 \times 10^{5}$ | Bit Periods Bit Periods Bit Periods |
| POWER SUPPLY <br> Voltage ( $\mathrm{V}_{\text {MIN }}$ to $\mathrm{V}_{\text {MAX }}$ ) Current | $\begin{aligned} & \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{~V}_{\mathrm{EE}}=-5.2 \mathrm{~V} \end{aligned}$ | $-4.5$ | $\begin{aligned} & -5.2 \\ & 125 \end{aligned}$ | $\begin{aligned} & -5.5 \\ & 170 \\ & 180 \end{aligned}$ | $-4.5$ | $\begin{aligned} & -5.2 \\ & 125 \end{aligned}$ | $\begin{aligned} & -5.5 \\ & 170 \\ & 180 \end{aligned}$ | -4.5 | $\begin{aligned} & -5.2 \\ & 140 \end{aligned}$ | $\begin{aligned} & -5.5 \\ & 180 \\ & 205 \end{aligned}$ | Volts mA mA |
| INPUT VOLTAGE LEVELS <br> Input Logic High, $\mathrm{V}_{\text {IH }}$ Input Logic Low, $\mathrm{V}_{\mathrm{IH}}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | $\begin{aligned} & -1.084 \\ & -1.95 \end{aligned}$ |  | $\begin{aligned} & -0.72 \\ & -1.594 \end{aligned}$ | $\begin{aligned} & -1.084 \\ & -1.95 \end{aligned}$ |  | $\begin{aligned} & -0.72 \\ & -1.594 \end{aligned}$ | $\begin{array}{\|l} -1.084 \\ -1.95 \end{array}$ |  | $\begin{aligned} & -0.72 \\ & -1.594 \end{aligned}$ | Volts Volts |
| OUTPUT VOLTAGE LEVELS <br> Output Logic High, $\mathrm{V}_{\mathrm{OH}}$ Output Logic Low, $\mathrm{V}_{\text {OL }}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | $\begin{aligned} & -1.084 \\ & -1.95 \end{aligned}$ |  | $\begin{aligned} & -0.72 \\ & -1.60 \end{aligned}$ | $\begin{aligned} & -1.084 \\ & -1.95 \end{aligned}$ |  | $\begin{aligned} & -0.72 \\ & -1.60 \end{aligned}$ | $\begin{aligned} & -1.084 \\ & -1.95 \end{aligned}$ |  | $\begin{aligned} & -0.72 \\ & -1.60 \end{aligned}$ | Volts Volts |
| INPUT CURRENT LEVELS <br> Input Logic High, $\mathrm{I}_{\mathrm{IH}}$ Input Logic Low, $\mathrm{I}_{\mathrm{IL}}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |  |  | $\begin{aligned} & 125 \\ & 80 \end{aligned}$ |  |  | $\begin{aligned} & 125 \\ & 80 \end{aligned}$ |  |  | $\begin{aligned} & 125 \\ & 80 \end{aligned}$ | $\begin{aligned} & \mu \mathbf{A} \\ & \mu \mathbf{A} \end{aligned}$ |
| ```OUTPUT SLEW TIMES Rise Time (t, Fall Time (trg)``` | $\begin{aligned} & \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & 20 \%-80 \% \\ & 80 \%-20 \% \end{aligned}$ |  | $\begin{aligned} & 0.75 \\ & 0.75 \end{aligned}$ | $\begin{aligned} & 1.5 \\ & 1.5 \end{aligned}$ |  | $\begin{aligned} & 0.75 \\ & 0.75 \end{aligned}$ | $\begin{aligned} & 1.5 \\ & 1.5 \end{aligned}$ |  | $\begin{aligned} & 0.75 \\ & 0.75 \end{aligned}$ | $\begin{aligned} & 1.5 \\ & 1.5 \end{aligned}$ | $\begin{array}{\|l\|} \mathrm{ns} \\ \mathrm{~ns} \end{array}$ |
| SYMMETRY <br> Recovered Clock Output | $\begin{aligned} & \rho=1 / 2, T_{A}=+25^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{EE}}=-5.2 \mathrm{~V} \end{aligned}$ | 45 |  | 55 | 45 |  | 55 | 45 |  | 55 | \% |

## NOTES

${ }^{1}$ Refer to Glossary for parameter definition.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS*

| Supply Voltage | V |
| :---: | :---: |
| Input Voltage ( $\operatorname{Pin} 16$ or Pin 17 to $\mathrm{V}_{\mathrm{CC}}$ ) | $\mathrm{V}_{\mathrm{EE}}$ to +300 mV |
| Maximum Junction Temperature |  |
| SOIC Package | $+150^{\circ} \mathrm{C}$ |
| Ceramic DIP Package | $+175^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Lead Temperature Range (Soldering 60 sec ) | $+300^{\circ} \mathrm{C}$ |
| ESD Rating |  |
| AD800 | 1500 V |
| AD802 | 1000 V |

*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to an absolute maximum rating condition for an extended period may adversely affect device reliability.


Figure 1. Recovered Clock Skew and Setup (See Previous Page)

PIN DESCRIPTIONS

| Number | Mnemonic | Description |
| :---: | :---: | :---: |
| 1 | DATAOUT | Differential Retimed Data Output |
| 2 | DATAOUT | Differential Retimed Data Output |
| 3 | $\mathrm{V}_{\mathrm{CC} 2}$ | Digital Ground |
| 4 | CLKOUT | Differential Recovered Clock Output |
| 5 | CLKOUT | Differential Recovered Clock Output |
| 6 | $\mathrm{V}_{\text {EE }}$ | Digital $\mathrm{V}_{\text {EE }}$ |
| 7 | $\mathrm{V}_{\text {EE }}$ | Digital $\mathrm{V}_{\mathrm{EE}}$ |
| 8 | $\mathrm{V}_{\mathrm{CC} 1}$ | Digital Ground |
| 9 | $\mathrm{AV}_{\text {EE }}$ | Analog $\mathrm{V}_{\text {EE }}$ |
| 10 | ASUBST | Analog Substrate |
| 11 | $\mathrm{CF}_{2}$ | Loop Damping Capacitor Input |
| 12 | $\mathrm{CF}_{1}$ | Loop Damping Capacitor Input |
| 13 | $\mathrm{AV}_{\text {CC }}$ | Analog Ground |
| 14 | $\mathrm{V}_{\mathrm{CC} 1}$ | Digital Ground |
| 15 | $\mathrm{V}_{\text {EE }}$ | Digital $\mathrm{V}_{\text {EE }}$ |
| 16 | DATAIN | Differential Data Input |
| 17 | DATAIN | Differential Data Input |
| 18 | SUBST | Digital Substrate |
| 19 | $\overline{\text { FRAC }}$ | Differential Frequency Acquisition Indicator Output |
| 20 | FRAC | Differential Frequency Acquisition Indicator Output |

## THERMAL CHARACTERISTICS

|  | $\boldsymbol{\theta}_{\mathbf{J C}}$ | $\boldsymbol{\theta}_{\mathbf{J A}}$ |
| :--- | :--- | :--- |
| SOIC Package | $22^{\circ} \mathrm{C} / \mathrm{W}$ | $75^{\circ} \mathrm{C} / \mathrm{W}$ |
| Cerdip Package | $25^{\circ} \mathrm{C} / \mathrm{W}$ | $90^{\circ} \mathrm{C} / \mathrm{W}$ |

Use of a heatsink may be required depending on operating environment.

## GLOSSARY

## Maximum and Minimum Specifications

Maximum and minimum specifications result from statistical analyses of measurements on multiple devices and multiple test systems. Typical specifications indicate mean measurements. Maximum and minimum specifications are calculated by adding or subtracting an appropriate guardband from the typical specification. Device-to-device performance variation and test system-to-test system variation contribute to each guardband.

## Nominal Center Frequency

This is the frequency that the VCO will operate at with no input signal present and the loop damping capacitor, $\mathrm{C}_{\mathrm{D}}$, shorted.

## Tracking Range

This is the range of input data rates over which the PLL will remain in lock.

## Capture Range

This is the range of input data rates over which the PLL can acquire lock.

## Static Phase Error

This is the steady-state phase difference, in degrees, between the recovered clock sampling edge and the optimum sampling instant, which is assumed to be halfway between the rising and falling edges of a data bit. Gate delays between the signals that define static phase error, and IC input and output signals prohibit direct measurement of static phase error.

## Data Transition Density, $\rho$

This is a measure of the number of data transitions, from " 0 " to " 1 " and from " 1 " to " 0 ," over many clock periods. $\rho$ is the ratio

## Jitter

This is the dynamic displacement of digital signal edges from their long term average positions, measured in degrees rms, or Unit Intervals (UI). Jitter on the input data can cause dynamic phase errors on the recovered clock sampling edge. Jitter on the recovered clock causes jitter on the retimed data.

## Output Jitter

This is the jitter on the retimed data, in degrees rms, due to a specific pattern or some psuedo-random input data sequence (PRN Sequence).

## Jitter Tolerance

Jitter tolerance is a measure of the PLL's ability to track a jittery input data signal. Jitter on the input data is best thought of as phase modulation, and is usually specified in unit intervals.

ORDERING GUIDE

| Device | Center Frequency | Fractional Loop Bandwidth | Description | Operating Temperature | Package Option |
| :--- | :---: | :---: | :--- | :---: | :---: |
| AD800-45BQ | 44.736 MHz | $0.1 \%$ | $20-$-Pin Cerdip | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Q-20 |
| AD800-52BR | 51.84 MHz | $0.1 \%$ | 20 -Pin Plastic SOIC | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | R-20 |
| AD802-155BR | 155.52 MHz | $0.08 \%$ | 20 -Pin Plastic SOIC | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | R-20 |
| AD802-155KR | 155.52 MHz | $0.08 \%$ | 20 -Pin Plastic SOIC | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | R-20 |

[^225]The PLL must provide a clock signal which tracks this phase modulation in order to accurately retime jittered data. In order for the VCO output to have a phase modulation which tracks the input jitter, some modulation signal must be generated at the output of the phase detector (see Figure 21). The modulation output from the phase detector can only be produced by a phase error between the data input and the clock input. Hence, the PLL can never perfectly track jittered data. However, the magnitude of the phase error depends on the gain around the loop. At low frequencies the integrator provides very high gain, and thus very large jitter can be tracked with small phase errors between input data and recovered clock. At frequencies closer to the loop bandwidth, the gain of the integrator is much smaller, and thus less input jitter can be tolerated. The PLL data output will have a bit error rate less than $1 \times 10^{-10}$ when in lock and retiming input data that has the specified jitter applied to it.

## Jitter Transfer

The PLL exhibits a low-pass filter response to jitter applied to its input data.

## Bandwidth

This describes the frequency at which the PLL attenuates sinusoidal input jitter by 3 dB .

## Peaking

This describes the maximum jitter gain of the PLL in dB.
Damping Factor, $\zeta$
$\zeta$ describes how the PLL will track an input signal with a phase step. A greater value of $\zeta$ corresponds to less overshoot in the PLL response to a phase step. $\zeta$ is a standard constant in second order feedback systems.

## Acquisition Time

This is the transient time, measured in bit periods, required for the PLL to lock on input data from its free-running state.

## Symmetry

Symmetry is calculated as ( $100 \times$ on time)/period, where on time equals the time that the clock signal is greater than the midpoint between its " 0 " level and its " 1 " level.

## Bit Error Rate vs. Signal-to-Noise Ratio

The AD800 and AD802 were designed to operate with standard ECL signal levels at the data input. Although not recommended, smaller input signals are tolerable. Figure 8,14 , and 20 show the bit error rate performance versus input signal-to-noise ratio for input signal amplitudes of full 900 mV ECL, and decreased amplitudes of 80 mV and 20 mV . Wideband amplitude noise is summed with the data signals as shown in Figure 2. The full ECL and 80 mV signals give virtually indistinguishable results. The 20 mV signals also provide adequate performance when in lock, but signal acquisition may be impaired.


Figure 2. Bit Error Rate vs. Signal-to-Noise Ratio Test: Block Diagram

## USING THE AD800 AND THE AD802 SERIES

## Ground Planes

Use of one ground plane for connections to both analog and digital grounds is recommended. Output signal sensitivity to power supply noise (PECL configuration, Figure 22) is less using one ground plane than when using separate analog and digital ground planes.

## Power Supply Connections

Use of a $10 \mu \mathrm{~F}$ tantalum capacitor between $\mathrm{V}_{\mathrm{EE}}$ and ground is recommended.

Use of $0.1 \mu \mathrm{~F}$ ceramic capacitors between IC power supply or substrate pins and ground is recommended. Power supply decoupling should take place as close to the IC as possible. Refer to schematics, Figure 22 and Figure 26, for advised connections.
Sensitivity of IC output signals (PECL configuration, Figure 22) to high frequency power supply noise (at $2 \times$ the nominal data rate) can be reduced through the connection of signals $A V_{C C}$ and $\mathrm{V}_{\mathrm{CC}}$, and the addition of a bypass network. The type of bypass network to consider depends on the noise tolerance required. The more complex bypass network schemes tolerate greater power supply noise levels. Refer to Figures 23 and 24 for bypassing schemes and power supply sensitivity curves.

## Transmission Lines

Use of $50 \Omega$ transmission lines are recommended for DATAIN, CLKOUT, DATAOUT, and FRAC signals.

## Terminations

Termination resistors should be used for DATAIN, CLKOUT, DATAOUT, and FRAC signals. Metal, thick film, $1 \%$ tolerance resistors are recommended. Termination resistors for the DATAIN signals should be placed as close as possible to the DATAIN pins.
Connections form $\mathrm{V}_{\mathrm{EE}}$ to lead resistors for DATAIN, DATAOUT, FRAC, and CLKOUT signals should be individual, not daisy chained. This will avoid crosstalk on these signals.
Loop Damping Capacitor, $\mathbf{C}_{\mathbf{D}}$
A ceramic capacitor may be used for the loop damping capacitor.

## Input Buffer

Use of an input buffer, such as a 10H116 Line Receiver IC, is suggested for an application where the DATAIN signals do not come directly from an ECL gate; or where noise immunity on the DATAIN signals is an issue.

## Typical Characteristics



Figure 3. AD800-45 Center Frequency vs. Temperature


Figure 5. AD800-45 Capture and Tracking Range vs. Temperature


Figure 7. AD800-45 Acquisition Range vs. Input Jitter


Figure 4. AD800-45 Jitter vs. Temperature


Figure 6. AD800-45 Jitter Tolerance


Figure 8. AD800-45 Bit Error Rate vs. Input Jitter


Figure 9. AD800-52 Center Frequency vs. Temperature


Figure 11. AD800-52 Capture and Tracking Range vs. Temperature


Figure 13. AD800-52 Acquisition Range vs. Input Jitter


Figure 10. AD800-52 Jitter vs. Temperature


Figure 12. AD800-52 Jitter Tolerance


Figure 14. AD800-52 Bit Error Rate vs. Input Jitter


Figure 15. AD802-155 Center Frequency vs. Temperature


Figure 17. AD802-155 Capture Range, Tracking Range vs. Temperature


Figure 19. AD802-155 Minimum Acquisition Range vs. Jitter Frequency, $T_{\text {MIN }}$ to $T_{\text {MAX }}, V_{\text {MIN }}$ to $V_{\text {MAX }}$


Figure 16. AD802-155 Output Jitter vs. Temperature


Figure 18. AD802-155 Jitter Tolerance


Figure 20. AD802-155 Bit Error Rate vs. Input Jitter

## AD800/AD802

## THEORY OF OPERATION

The AD800 and AD802 are phase-locked loop circuits for recovery of clock from NRZ data. The architecture uses a frequency detector to aid initial frequency acquisition, refer to Figure 21 for a block diagram. Note the frequency detector is always in the circuit. When the PLL is locked, the frequency error is zero and the frequency detector has no further effect. Since the frequency detector is always in circuit, no control functions are needed to initiate acquisition or change mode after acquisition. The frequency detector also supplies a frequency acquisition (FRAC) output to indicate when the loop is acquiring lock. During the frequency acquisition process the FRAC output is a series of pulses of width equal to the period of the VCO. These pulses occur on the cycle slips between the data frequency and the VCO frequency. With a maximum density (1010 . . .) data pattern, every cycle slip will produce a pulse at FRAC. However, with random data, not every cycle slip produces a pulse. The density of pulses at FRAC increases with the density of data transitions. The probability that a cycle slip will produce a pulse increases as the frequency error approaches zero. After the frequency error has been reduced to zero, the FRAC output will have no further pulses. At this point the PLL begins the process of phase acquisition, with a settling time of roughly 2000 bit periods. Valid retimed data can be guaranteed by waiting 2000 bit periods after the last FRAC pulse has occurred.

Jitter caused by variations of density of data transitions (pattern jitter) is virtually eliminated by use of a new phase detector (patented). Briefly, the measurement of zero phase error does not cause the VCO phase to increase to above the average run rate set by the data frequency. The jitter created by a $2^{7}-1$ pseudo-random code is $1 / 2$ degree, and this is small compared to random jitter.

The jitter bandwidth for the AD802-155 is $0.08 \%$ of the center frequency. This figure is chosen so that sinusoidal input jitter at 130 kHz will be attenuated by 3 dB . The jitter bandwidths of the AD800-45 and AD800-52 are $0.1 \%$ of the respective center frequencies. The jitter bandwidth of the AD800 or the AD802 is mask programmable from $0.01 \%$ to $1 \%$ of the center frequency. A device with a very low loop bandwidth $(0.01 \%$ of the center frequency) could effectively filter (clean up) a jittery timing reference. Consult the factory if your application requires a special loop bandwidth.

The damping ratio of the phase-locked loop is user programmable with a single external capacitor. At 155 MHz a damping ratio of 10 is obtained with a $0.22 \mu \mathrm{~F}$ capacitor. More generally, the damping ratio scales as $1.7 \times \sqrt{f_{D A T A} \times C_{D}}$. At 155 MHz a damping ratio of 1 is obtained with a 2.2 nF capacitor. A lower damping ratio allows a faster frequency acquisition; generally the acquisition time scales directly with the capacitor value. However, at damping ratios approaching one, the acquisition time no longer scales directly with the capacitor value. The acquisition time has two components: frequency acquisition and phase acquisition. The frequency acquisition always scales with capacitance, but the phase acquisition is set by the loop bandwidth of the PLL and is independent of the damping ratio. Thus, the $0.08 \%$ fractional loop bandwidth sets a minimum acquisition time of 15,000 bit periods. Note the acquisition time for a damping factor of 1 is specified as 15,000 bit periods. This comprises 13,000 bit periods for frequency acquisition and 2,000 periods for phase acquisition. Compare this to the 400,000 bit periods acquisition time specified for a damping ratio of 5; this consists entirely of frequency acquisition, and the 2,000 bit periods of phase acquisition is negligible.
While lower damping ratio affords faster acquisition, it also allows more peaking in the jitter transfer response (jitter peaking). For example, with a damping ratio of 10 the jitter peaking is 0.02 dB , but with a damping factor of 1 , the peaking is 2 dB .


Figure 21. AD800 and AD802 Block Diagram


Figure 22. Evaluation Board Schematic, Positive Supply
Table I. Evaluation Board, Positive Supply: Components List

| Reference <br> Designator | Description |  |
| :--- | :--- | :--- |
| R1-8, R15-18 | Resistor, $100 \Omega, 1 \%$ | 12 |
| R9-14 | Resistor, $154 \Omega, 1 \%$ | 6 |
| R19,20, 23, 24 | Resistor, $130 \Omega, 1 \%$ | 4 |
| R21, 22,25, 26 | Resistor, $80.6 \Omega, 1 \%$ | 4 |
| C $_{\text {D }}$ | Capacitor, Loop Damping (See Specifications Page) | 1 |
| C2 | Capacitor, $10 \mu \mathrm{~F}$, Tantalum | 1 |
| C3-C21 | Capacitor, 0.1 $\mu \mathrm{F}$, Ceramic Chip | 17 |
| Z1 | AD800/AD802 | 1 |
| Z2 | 10H116, ECL Line Receiver | 1 |



BYPASS NETWORK
BYPASS NETWO
COMPONENTS:
COMPONENTS
CAPACITOR .........CERAMIC CHIP
Figure 23. Bypass Network Schemes


Figure 24. AD802-155 Output Jitter vs. Supply Noise (PECL Configuration)


Figure 25. Power Supply Noise Sensitivity Test Circuit, PECL Configuration


Figure 26. Evaluation Board Schematic, Negative Supply

Table II. Evaluation Board, Negative Supply: Components List

| Reference Designator | Description | Quantity |
| :--- | :--- | :--- |
| R1-8 | Resistor, $100 \Omega, 1 \%$ | 8 |
| R9-12 | Resistor, $154 \Omega, 1 \%$ | 4 |
| R13, 14, 17, 18 | Resistor, $80.6 \Omega, 1 \%$ | 4 |
| R15, 16, 19, 20 | Resistor, $130 \Omega, 1 \%$ | 4 |
| R21, 22 | Resistor, $274,1 \%$ | 2 |
| C $_{\text {D }}$ | Capacitor, Loop Damping (See Specifications Page) | 1 |
| C2 | Capacitor, $10 \mu \mathrm{~F}$, Tantalum | 1 |
| C3-C12 | Capacitor, $0.1 \mu \mathrm{~F}$, Ceramic Chip | 10 |
| Z1 | AD800/AD802 | 1 |
| Z2 | 10H116, ECL Line Receiver | 1 |



Figure 27. Negative Supply Configuration: Component
Side (Top Layer)


AD800/AD802

Figure 30. Positive Supply Configuration: Solder
Side


Figure 29, Positive Supply Configuration: Component
Side (Top Layer)


FEATURES
RS-232 and RS-422 on One Chip
Single +5 V Supply
$0.1 \mu \mathrm{~F}$ Capacitors
Short Circuit Protection Excellent Noise Immunity Low Power BiCMOS Technology
High Speed, Low Skew RS-422 Operation
$-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ Operation

## APPLICATIONS <br> DTE-DCE Interface <br> Packet Switching <br> Local Area Networks <br> Data Concentration <br> Data Multiplexers <br> Integrated Services Digital Network (ISDN)

## GENERAL DESCRIPTION

The AD7306 line driver/receiver is a 5 V monolithic product which provides an interface between TTL signal levels and dual standard EIA RS-232/RS-422 signal levels. The part contains two RS-232 drivers, one RS-422 driver, one RS-232 receiver,' and one receiver path which can be configured either as RS-232 or as RS-422.

An internal charge pump voltage converter facilitates operation from a single +5 V power supply. The internal charge pump generates $\pm 10 \mathrm{~V}$ levels allowing RS-232 output levels to be developed without the need for external bipolar power supplies.
A highly efficient charge pump design allows operation using non polarized, miniature $0.1 \mu \mathrm{~F}$ capacitors. This gives a considerable saving in printed circuit board space over conventional products which can use up to $10 \mu \mathrm{~F}$ capacitors. The charge pump output voltages may also be used to power external circuitry which requires dual supplies.

FUNCTIONAL BLOCK DIAGRAM


The RS-232 channels are suitable for communications rates up to 100 kHz and the RS-422 channels are suitable for high speed communications up to 5 MHz . The RS- 422 transmitter complementary outputs are closely matched and feature low timing skew between the complementary outputs. This is often an essential requirement to meet tight system timing specifications.

All inputs feature ESD protection, all driver outputs feature high source and sink current capability and are internally protected against short circuits on the outputs. An epitaxial layer is used to guard against latch-up.
The part is available in a 24 -lead SOIC and 24-pin plastic DIP packages.

| Parameter | Min | Typ | Max | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| RS-232 DRIVER |  |  |  |  |  |
| TTL Input Logic Low, $\mathrm{V}_{\text {INL }}$ |  |  | 0.8 | V |  |
| TTL Input Logic High, $\mathrm{V}_{\text {INH }}$ | 2.0 |  |  | V |  |
| Input Logic Current |  | 0.1 | $\pm 10$ | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ to $\mathrm{V}_{\text {CC }}$ |
| RS-232 High Level Output Voltage | 5.0 | 7.3 |  | V | $\mathrm{R}_{\mathrm{L}}=3 \mathrm{k} \Omega$ |
| RS-232 Low Level Output Voltage | -5.0 | -6.5 |  | V | $\mathrm{R}_{\mathrm{L}}=3 \mathrm{k} \Omega$ |
| Output Short Circuit Current | $\pm 5$ | $\pm 12$ |  | mA | $\mathrm{V}_{\text {OUT }}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ |
| Slew Rate | 8 | 20 | 30 | V/ $/ \mathrm{s}$ | $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=3 \mathrm{k} \Omega$ |
|  |  | 4 |  | V/ $/ \mathrm{s}$ | $\mathrm{C}_{\mathrm{L}}=2500 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=3 \mathrm{k} \Omega$ |
| Output Resistance (Powered Down) | 300 | 10M |  | $\Omega$ | $\mathrm{V}_{\mathrm{CC}}=0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}= \pm 3 \mathrm{~V}$ |
| RS-232 RECEIVER |  |  |  |  |  |
| Input Voltage Range | -15 |  | +15 | V |  |
| RS-232 Input Threshold Low | 0.8 | 1.3 |  | V |  |
| RS-232 Input Threshold High |  | 1.7 | 2.4 | V |  |
| RS-232 Input Hysteresis | 0.1 | 0.4 | 1.0 | V |  |
| RS-232 Input Resistance | 3 | 5 | 7 | $\mathrm{k} \Omega$ |  |
| TTL Output Voltage Low, $\mathrm{V}_{\mathrm{OL}}$ |  | 0.2 | 0.4 | V | $\mathrm{I}_{\text {Out }}=+4 \mathrm{~mA}$ |
| TTL Output Voltage High, $\mathrm{V}_{\mathrm{OH}}$ | 3.5 | 4.8 |  | V | $\mathrm{I}_{\text {OUT }}=-4 \mathrm{~mA}$ |
| RS-422 DRIVER |  |  |  |  |  |
| TTL Input Logic Low, $\mathrm{V}_{\text {INL }}$ |  |  | 0.8 | V |  |
| TTL Input Logic High, $\mathrm{V}_{\text {INH }}$ | 2.0 |  |  | V |  |
| Logic Input Current |  | 0.1 | $\pm 10$ | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{CC}}$ |
| Differential Output Voltage |  |  | 5.0 | V | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}$ Diff $=\infty$; Figure 3 |
|  | 2 |  |  | V | $\mathrm{R}_{\mathrm{L}}$ Diff $=100 \Omega$; Figure 3 |
| Common-Mode Output Voltage |  |  | 3 | V |  |
| $\Delta\left\|\mathrm{V}_{\text {OuT }}\right\|$ for Complementary O/P States |  |  | 0.2 | V | $\mathrm{R}_{\mathrm{L}}$ Diff $=100 \Omega$ |
| Output Short Circuit Current | 35 |  | 150 | mA | $0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CMR}} \leq+7 \mathrm{~V}$ |
| RS-422 RECEIVER |  |  |  |  |  |
| Common-Mode Voltage Range |  |  | $\pm 7$ | V | Typical RS-422 Input Voltage $<5 \mathrm{~V}$ |
| Differential Input Threshold Voltage | -0.2 |  | +0.2 | V |  |
| Input Voltage Hysteresis |  | 70 |  | mV | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ |
| Input Resistance | 3 | 5 | 7 | k $\Omega$ |  |
| TTL Output Voltage Low, $\mathrm{V}_{\text {OL }}$ |  | 0.2 | 0.4 | V | $\mathrm{I}_{\text {OUT }}=+4.0 \mathrm{~mA}$ |
| TTL Output Voltage High, $\mathrm{V}_{\mathrm{OH}}$ | 3.5 | 4.8 |  | V | $\mathrm{I}_{\text {OUT }}=-4.0 \mathrm{~mA}$ |
| 232/422 SEL Input |  |  |  |  |  |
| Input Logic Low, $\mathrm{V}_{\text {INL }}$ |  |  | 0.8 | V |  |
| Input Logic High, $\mathrm{V}_{\text {INH }}$ | 2.0 |  |  | V |  |
| Logic Input Current |  | 0.1 | $\pm 10$ | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{CC}}$ |
| POWER SUPPLY CURRENT |  |  |  |  |  |
| $\mathrm{I}_{\mathrm{CC}}$ |  | 10 | 15 | mA | Outputs Unloaded |
| CHARGE PUMP VOLTAGE GENERATOR |  |  |  |  |  |
| V+ Output Voltage |  | 9 |  | V | RS-232 Output Unloaded; See Typical Performance Curves |
| V- Output Voltage |  | -9 |  | V | RS-232 Outputs Unloaded; <br> See Typical Performance Curves |
| Generator Rise Time |  | 200 |  | $\mu \mathrm{s}$ |  |

Specifications subject to change without notice.

TIMING SPECIFICATIONS $\begin{aligned} & \left(\begin{array}{l}\left(V_{c c}=+5 \mathrm{~V}\right. \\ \text { unless otherwise noted. })\end{array}\right.\end{aligned}$

| Parameter | Typ | Max | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: |
| RS-422 Driver |  |  |  |  |
| Propagation Delay Input to Output $\mathrm{T}_{\text {PLH }}, \mathrm{T}_{\text {PHL }}$ | 35 | 100 | ns | $\mathrm{R}_{\mathrm{L}}$ Diff $=100 \Omega, \mathrm{C}_{\mathrm{L} 1}=\mathrm{C}_{\mathrm{L} 2}=100 \mathrm{pF}$, Figures 2 \& 4 |
| RS-422 O/P to $\overline{\mathrm{O} / \mathrm{P}} \mathrm{T}_{\text {Skew }}$ | 2 | 10 | ns | $\mathrm{R}_{\mathrm{L}}$ Diff $=100 \Omega, \mathrm{C}_{\mathrm{L} 1}=\mathrm{C}_{\mathrm{L} 2}=100 \mathrm{pF}$, Figures 2 \& 4 |
| Driver Rise/Fall Time $\mathrm{T}_{\mathrm{R}}, \mathrm{T}_{\mathrm{F}}$ | 15 | 40 | ns | $\mathrm{R}_{\mathrm{L}}$ Diff $=100 \Omega, \mathrm{C}_{\mathrm{L} 1}=\mathrm{C}_{\mathrm{L} 2}=100 \mathrm{pF}$, Figures 2 \& 4 |
| RS-422 Receiver |  |  |  |  |
| Propagation Delay Input to Output $\mathrm{T}_{\text {PLH }}, \mathrm{T}_{\text {PHL }}$ | 70 | 200 | ns | $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$. Figure 5 |
| RS-232/RS-422 Enable |  |  |  |  |
| RS-232 Disable to RS-422 Enable $\mathrm{T}_{\mathrm{EN} 1}$ | 70 | 200 | ns | Figure 6 |
| RS-422 Disable to RS-232 Enable $\mathrm{T}_{\mathrm{EN} 2}$ | 70 | 200 | ns | Figure 6 |
| Transmission Rate (RS-422) | 5 |  | MHz |  |
| RS-232 Receiver |  |  |  |  |
| Propagation Delay Input to Output | 1000 |  | ns |  |
| Transmission Rate (RS-232) | 100 |  | kHz | $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ |
|  | 20 |  | kHz | $\mathrm{C}_{\mathrm{L}}=2.5 \mathrm{nF}$ |

## ABSOLUTE MAXIMUM RATINGS*

( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise noted)
$\mathrm{V}_{\mathrm{Cc}}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . +7 V
$\mathrm{V}+\ldots . . . . . . . . . . . . . . . . . .\left(V_{\mathrm{CC}}-0.3 \mathrm{~V}\right)$ to +13.2 V
V- . . . . . . . . . . . . . . . . . . . . . . . . . +0.3 V to -13.2 V
Inputs


Outputs
$\mathrm{Tl}_{\text {Out }}, \mathrm{T}_{\text {out }}$. . . . . . . . . . . . . . . . . . . -15 V to +15 V

$\mathrm{Rl}_{\mathrm{out}}, \mathrm{R} 2_{\mathrm{out}} \ldots . . . . . . . . .-0.3 \mathrm{~V}$ to $\left(\mathrm{V}_{\mathrm{CC}}+0.3 \mathrm{~V}\right)$

Short Circuit Duration
Tout . . . . . . . . . . . . . . . . . . . . . . . . . . . . Continuous
Power Dissipation
Small Outline . . . . . . . . . . . . . . . . . . . . . . . . . 650 mW
DIP . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 650 mW
Operating Temperature Range
Commercial (J Version) . . . . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Industrial (A Version) . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 secs) . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum ratings for extended periods of time may affect device reliability.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD7306 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


ORDERING GUIDE

| Model | Temperature Range | Package Description | Package Option* |
| :--- | :--- | :--- | :--- |
| AD7306JR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 24-Lead SOIC | $\mathrm{R}-24$ |
| AD7306JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 24-Pin DIP | $\mathrm{N}-24$ |
| AD7306AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 24-Lead SOIC | $\mathrm{R}-24$ |
| AD7306AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 24-Pin DIP | $\mathrm{N}-24$ |

[^226]PIN FUNCTION DESCRIPTION

| SOIC <br> Pin | $\begin{aligned} & \text { DIP } \\ & \text { Pin } \end{aligned}$ | Mnemonic | Function |
| :---: | :---: | :---: | :---: |
| 1 | 19 | V+ | Internally Generated Positive Supply ( +9 V nominal). A $0.1 \mu \mathrm{~F}$ capacitor must be connected between this pin and GND. |
| 2, 3 | 20, 22 | Cl+, $\mathrm{Cl}-$ | External Capacitor 1 Terminals. A $0.1 \mu \mathrm{~F}$ capacitor must be connected between these pins. |
| 4 | 23 | $\mathrm{R} 2_{\text {IN }}$ | RS-232 Receiver R2 Input. This input accepts RS-232 input voltages. |
| 5 | 24 | T1 ${ }_{\text {OUT }}$ | RS-232 Transmitter (Driver) T1 Output (Typically $\pm 7.5 \mathrm{~V}$ ). |
| 6 | 1 | T2 ${ }_{\text {OUT }}$ | RS-232 Transmitter (Driver) T2 Output (Typically $\pm 7.5 \mathrm{~V}$ ). |
| 7 | 2 | $\mathrm{V}_{\mathrm{CC}}$ | Power Supply Input ( $5 \mathrm{~V} \pm 5 \%$ ). |
| 8 | 3 | $\mathrm{R} 1_{\text {IN }}$ (B) | RS-422 Receiver R1, Differential Input B. |
| 9 | 4 | $\mathrm{R} 1_{\text {IN }} / \mathrm{R} 1_{\text {IN }}$ (A) | Receiver R1 Input. May be configured to accept either single ended RS-232 levels or differential RS-422 levels. It is configured using the 232/422 SEL pin. |
| 10 | 5 | T3 ${ }_{\text {Out }}(\mathrm{B})$ | RS-422 Transmitter (Driver) T3, Differential Output B. |
| 11 | 6 | T3 ${ }_{\text {OUt }}$ (A) | RS-232 Transmitter (Driver) T3, Differential Output A. |
| 12, 13 | 16, 21 | NC | No Connect Pins. |
| 14, 18 | 7, 11 | GND | Ground Pin. Must be connected to 0 V . |
| 15 | 8 | 232/422 SEL | Select Input. This input configures Receiver R1 to accept either RS-232 or RS-422 signal levels. A Logic 1 on this input selects 232 operation while a Logic 0 selects 422 operation. |
| 16 | 9 | T3 ${ }_{\text {IN }}$ | TTL/CMOS Input to the RS-422 Transmitter T3. |
| 17 | 10 | $\mathrm{R} 1_{\text {OUT }}$ | TTL/CMOS Output from Receiver R1. |
| 19 | 12 | T2 IN | TTL/CMOS Input to RS-232 Transmitter T2. |
| 20 | 13 | $\mathrm{Tl}_{\mathrm{IN}}$ | TTL/CMOS Input to RS-232 Transmitter T1. |
| 21 | 14 | R2 ${ }_{\text {Out }}$ | TTL/CMOS Output from Receiver R2. |
| 22, 23 | 15, 17 | C2+, $\mathrm{C} 2-$ | External Capacitor 2 Terminals. A $0.1 \mu \mathrm{~F}$ capacitor must be connected between these pins. |
| 24 | 18 | V- | Internally Generated Negative Supply ( -9 V nominal). A $0.1 \mu \mathrm{~F}$ capacitor must be connected between this pin and GND |




Figure 1. AD7306 Application Circuit (SOIC Package)


Figure 2. RS-422 Driver. Propagation Delay Test Circuit


Figure 3. RS-422 Driver. Voltage Measurement Test Circuit


Figure 4. RS-422 Driver. Propagation Delay, Rise/Fall Timing


Figure 5. RS-422 Receiver Timing


Figure 6. RS-232/RS-422 Receiver Enable Timing

## GENERAL DESCRIPTION

The AD7306 drivers/receivers provide an interface which is compatible with RS-232/RS-422 standard interfaces. As both standards are widely accepted it is often necessary to provide an interface which is compatible with both. The AD7306 is ideally suited to this type of application as both standards may be met using a single package. This part contains two RS-232 drivers, one RS-422 driver, one RS-232 receiver, and one receiver path which can be configured as either RS-232 or RS-422. This receiver is configured using the 232/422 SEL pin.
This part also contains an internal charge pump voltage converter which facilitates operation using a single +5 V power supply.

## Charge Pump DC-DC Voltage Generator

The charge pump voltage generator uses a switched capacitor technique to develop $\pm 10 \mathrm{~V}$ levels from an input +5 V supply. A highly efficient charge pump design coupled with a high frequency internal oscillator permit operation using four $0.1 \mu \mathrm{~F}$ capacitors.


Figure 7. Charge Pump Voltage Generator
Capacitors C1 and C2 act as charge storage capacitors while C3 and C4 provide output smoothing. For correct operation all four capacitors must be included. Either polarized or nonpolarized capacitors may be used for $\mathrm{Cl}-\mathrm{C} 4$. If a polarized type is used, then the correct polarity should be observed. This may be ignored with nonpolarized type capacitors.
The charge pump output voltages, $\mathrm{V}+$ and $\mathrm{V}-$, are used internally to power the RS-232 transmitters. This permits RS-232 output levels to be developed on the RS-232 transmitter outputs. The charge pump output voltages may also be used to power external circuitry if the current requirements are small. Please refer to the Typical Performance Characteristics.
The generator rise time after power up is $200 \mu s$ typical. This time is necessary to completely charge the storage capacitors in the charge pump. Therefore, RS-232 data transmission should not be initiated until this time has elapsed after switch on. This will ensure that valid data is always transmitted.

## RS-232 Drivers

The RS-232 drivers in the AD7306 meet the EIA RS-232 specifications. The drivers are inverting level shifters which convert TTL/CMOS levels into RS-232 output levels. The input switching threshold is typically 1.3 V . With a typical RS-232 load, the output levels are $\pm 7.5 \mathrm{~V}$. Under worst case load conditions, the drivers are guaranteed to provide $\pm 5 \mathrm{~V}$ which meets the minimum RS-232 requirement. The output slew rate is internally limited to $<30 \mathrm{~V} / \mu \mathrm{s}$ without the need for an external slewlimiting capacitor. Short circuit protection is also provided which prevents damage in the event of output fault conditions. Active current limiting is used which limits the output short circuit current to less than 12 mA in the event of an output fault. This type of current limiting does not degrade the output voltage swing under normal loading conditions as would be the case with conventional passive limiting.
The powered-down output impedance is typically $10 \mathrm{M} \Omega$. This is considerably larger than the $300 \Omega$ minimum value required by the RS-232 specification. It provides additional protection under fault conditions where another powered-up transmitter output is inadvertently shorted to the powered-down device.

## RS-232 Receivers

The receivers are inverting level shifters which accept RS-232 input levels ( $\pm 3 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$ ) and translates them into 5 V
TTL/CMOS levels. The input switching thresholds are 0.8 V minimum and 2.4 V maximum which are well within the RS- 232 requirement of $\pm 3 \mathrm{~V}$. Internal $5 \mathrm{k} \Omega$ pull-down resistors to GND are provided on the receiver inputs. This ensures that an unconnected input will be interpreted as a low level giving a Logic " 1 " on the TTL/CMOS output. Excellent noise immunity is achieved by the use of hysteresis and internal filtering circuitry. The filter rejects noise glitches of up to $0.5 \mu \mathrm{~s}$ in duration.

## RS-422 Driver

The RS-422 driver on the AD7306 accepts a TTL/CMOS input and translates it into a differential RS-422 level signal. The input switching threshold is typically 1.3 V . The unloaded output differential voltage is typically $\pm 5 \mathrm{~V}$ (see Typical Performance Characteristics). Short circuit protection is provided on the output which limits the current to less than 150 mA .

## RS-422 Receiver

The RS-422 receiver on the AD7306 accepts a differential input signal and translates it into a TTL/CMOS output level. The input resistance on both differential inputs is $5 \mathrm{k} \Omega$ typical. With the receiver inputs unconnected (floating), internal biasing ensures that the receiver output is a Logic " 1 ."
Excellent noise immunity and high transmission speed is achieved using the differential configuration.


Figure 8. V+ and V-Voltage vs. Current


Figure 9. RS-232 Driver Slew Rate vs. Load Capacitance


Figure 10. RS-232 Driver; $R_{L}=5 \mathrm{k} \Omega, C_{L}=50 \mathrm{pF}$


Figure 11. RS-232 Driver Output Voltage vs. Current


Figure 12. RS-422 Driver Output Current vs. Output Voltage


Figure 13. RS-422 Driver; $R_{\text {LDIFF }}=100 \Omega, C_{L 1}=C_{L 2}$ $=100 \mathrm{pF}$

## Single-Ended Data Transmission

Single-ended interfaces are used for low speed, short distance communications such as from a computer terminal to a printer. A single line is used to carry the signal. Various standards have been developed to standardize the communication link, the most popular of these being the RS-232. The RS-232 standard was introduced in 1962 by the EIA and has been widely used throughout the industry. The standard has been revised several times, and the current revision is known as EIA-232E. The RS-232 standard is suitable for single-ended data transmission at relatively slow data rates over short distances. A typical RS-232 interface is shown in Figure 14.


Figure 14. Single-Ended RS-232 Interface

## Differential Data Transmission

When transmitting at high data rates, over long distances and through noisy environments, single-ended data transmission is often inadequate. In this type of application, differential data transmission offers superior performance. Differential transmission uses two signal lines to transmit data. It rejects ground shifts and is insensitive to noise signals which appear as common mode voltages on the transmission lines. To accommodate faster data communication, the differential RS-422 standard was developed. Therefore, it can be used to reliably transmit data at higher speeds and over longer distances than single-ended transmission. A typical RS-422 interface is shown in Figure 15.


Figure 15. Differential RS-422 Interface

Table I. Comparison of RS-232 and RS-422
Interface Standards

| Specification | EIA-232E | RS-422 |
| :--- | :--- | :--- |
| Transmission Type | Single-Ended | Differential |
| Maximum Data Rate | $20 \mathrm{kB} / \mathrm{s}$ | $10 \mathrm{MB} / \mathrm{s}$ |
| Maximum Cable Length | Load Dependent | 4000 ft |
| Minimum Driver Output Voltage | $\pm 5 \mathrm{~V}$ | $\pm 1.5 \mathrm{~V}$ |
| Slew Rate | $30 \mathrm{~V} / \mu \mathrm{s} \max$ | - |
| Receiver Input Resistance | $3 \mathrm{k} \Omega$ to $7 \mathrm{k} \Omega$ | $4 \mathrm{k} \Omega \mathrm{min}$ |
| Receiver Input Sensitivity | $\pm 3 \mathrm{~V}$ | $\pm 200 \mathrm{mV}$ |
| Receiver Input Voltage Range | $\pm 15 \mathrm{~V}$ | $\pm 7 \mathrm{~V}$ |
| No. of Drivers per Line | 1 | 1 |
| No. of Receivers per Line | 1 | 10 |

## FEATURES

120 kB Transmission Rate
ADM202: Small ( $0.1 \mu F$ ) Charge Pump Capacitors
ADM203: No External Capacitors Required
Single 5 V Power Supply
Meets EIA-232-E and V. 28 Specifications
Two Drivers and Two Receivers
On-board DC-DC Converters
$\pm 9$ V Output Swing with +5 V Supply
Low Power BiCMOS: 2.0 mA $\mathrm{I}_{\text {cc }}$ $\pm 30$ V Receiver Input Levels

## APPLICATIONS

## Computers

Peripherals
Modems
Printers
Instruments

## GENERAL DESCRIPTION

The ADM202/ADM203 is a two-channel RS-232 line driver/ receiver pair designed to operate from a single +5 V power supply. A highly efficient on-chip charge pump design permits RS-232 levels to be developed using charge pump capacitors as small as $0.1 \mu \mathrm{~F}$. The capacitors are internal to the package on the ADM203 so no external capacitors are required. These converters generate $\pm 10 \mathrm{~V}$ RS- 232 output levels.
The ADM202/ADM203 meets or exceeds the EIA-232-E and V. 28 specifications. Fast driver slew rates permit operation up to 120 kB while high drive currents allows for extended cable lengths.
An epitaxial BiCMOS construction minimizes power consumption to 10 mW and also guards against latch-up. Overvoltage protection is provided allowing the receiver inputs to withstand continuous voltages in excess of $\pm 30 \mathrm{~V}$. In addition, all pins contain ESD protection to levels greater than 2 kV .
The ADM202 is available in 16-lead DIP and both narrow and wide SOIC packages. The ADM203 is available in a 20 -pin DIP package.

FUNCTIONAL BLOCK DIAGRAMS

*INTERNAL 400k $\Omega$ PULL-UP RESISTOR ON EACH TTL/CMOS INPUT **INTERNAL 5k $\Omega$ PULL-DOWN RESISTOR ON EACH RS-232 INPUT

| Parameter | Min | Typ | Max | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Output Voltage Swing | $\pm 5$ | $\pm 9$ |  | V | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V} \pm 5 \%, \mathrm{~T}_{\mathrm{OUT}}, \mathrm{T} 2_{\text {OUT }}$ Loaded with $3 \mathrm{k} \Omega$ to GND |
| Output Voltage Swing | $\pm 5$ | $\pm 9$ |  | V | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V} \pm 10 \%, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{T}_{\mathrm{OUT}}, \mathrm{T} 2_{\mathrm{OUT}}$ Loaded with $3 \mathrm{k} \Omega$ to GND |
| $\mathrm{V}_{\mathrm{CC}}$ Power Supply Current |  | 1.5 | 2 | mA | No Load, $\mathrm{T1}_{1 \mathrm{IN}}, \mathrm{T} 2_{\text {IN }}=\mathrm{V}_{\mathrm{CC}}$ |
|  |  | 3.0 | 4 | mA | No Load, $\mathrm{T1}_{1 \mathrm{IN}}, \mathrm{T} 2_{\text {IN }}=\mathrm{GND}$ |
| Input Logic Threshold Low, $\mathrm{V}_{\text {INL }}$ |  |  | 0.8 | V | $\mathrm{T}_{\text {IN }}$ |
| Input Logic Threshold High, $\mathrm{V}_{\text {INH }}$ | 2.0 |  |  | V | $\mathrm{T}_{\text {IN }}$ |
| Logic Pull-Up Current |  | 10 | 25 | $\mu \mathrm{A}$ | $\mathrm{T}_{\mathrm{IN}}=0 \mathrm{~V}$ |
| RS-232 Input Voltage Range | -30 |  | +30 | V |  |
| RS-232 Input Threshold Low | 0.8 | 1.2 |  | V |  |
| RS-232 Input Threshold High |  | 1.7 | 2.4 | V |  |
| RS-232 Input Hysteresis | 0.2 | 0.5 | 1.0 | V |  |
| RS-232 Input Resistance | 3 | 5 | 7 | k ת |  |
| TTL/CMOS Output Voltage Low, $\mathrm{V}_{\text {OL }}$ |  |  | 0.4 | V | $\mathrm{I}_{\text {OUT }}=1.6 \mathrm{~mA}$ |
| TTL/CMOS Output Voltage High, $\mathrm{V}_{\mathrm{OH}}$ | 3.5 |  |  | V | $\mathrm{I}_{\text {OUT }}=-1.0 \mathrm{~mA}$ |
| Propagation Delay |  | 0.5 | 5 | $\mu \mathrm{s}$ | RS-232 to TTL |
| Instantaneous Slew Rate ${ }^{1}$ |  | 25 | 30 | V/us | $\mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=3-7 \mathrm{k} \Omega, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |
| Transition Region Slew Rate |  | 5 |  | V/us | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=3 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=2500 \mathrm{pF} \\ & \text { Measured from }+3 \mathrm{~V} \text { to }-3 \mathrm{~V} \text { or }-3 \mathrm{~V} \text { to }+3 \mathrm{~V} \end{aligned}$ |
| Baud Rate | 120 |  |  | kB | $\mathrm{R}_{\mathrm{L}}=3 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=1 \mathrm{nF}$ |
| Output Resistance | 300 |  |  | $\Omega$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{V}+=\mathrm{V}-=0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}= \pm 2 \mathrm{~V}$ |
| RS-232 Output Short Circuit Current |  | $\pm 10$ | $\pm 60$ | mA |  |

## NOTE

${ }^{1}$ Sample tested to ensure compliance.
Specifications subject to change without notice.

| ABSOLUTE MAXIMUM RATINGS* <br> ( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted) |  |
| :---: | :---: |
| $\mathrm{V}_{\mathrm{Cc}}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . +6 t V |  |
| V+ | $\left(\mathrm{V}_{\mathrm{CC}}-0.3 \mathrm{~V}\right)$ to +14 V |
| V- . . . . . . . . . . . . . . . . . . . . . . . + +0.3 V to -14 V |  |
| Input Voltages |  |
| $\mathrm{T}_{\mathrm{IN}}$. . . . . . . . . . . . . . . . . | -0.3 V to $\left(\mathrm{V}_{\mathrm{CC}}+0.3 \mathrm{~V}\right)$ |
| $\mathrm{R}_{\text {IN }}$ | $\therefore \pm 30 \mathrm{~V}$ |
| Output Voltages |  |
| T ${ }_{\text {OUT }}$. . . . . . . . . . . . . (V+, +0, | $+0.3 \mathrm{~V})$ to ( $\mathrm{V}-,-0.3 \mathrm{~V}$ ) |
| $\mathrm{R}_{\text {OUT }}$. . . . . . . . . . . . . . . . . . | . -0.3 V to $\left(\mathrm{V}_{\mathrm{CC}}+0.3 \mathrm{~V}\right)$ |
| Short Circuit Duration |  |
| T ${ }_{\text {OUT }}$ | Continuous |
| Power Dissipation |  |
| N-16 DIP | 470 mW |
| R-16N SOIC | 600 mW |
| R-16W SOIC | 500 mW |
| N-20 DIP | 890 mW |
| Thermal Impedance |  |
| $\mathrm{N}-16$ DIP | $135^{\circ} \mathrm{C} / \mathrm{W}$ |
| R-16N SOIC | $105^{\circ} \mathrm{C} / \mathrm{W}$ |

R-16W SOIC . . . . . . . . . . . . . . . . . . . . . . . . . $105^{\circ} \mathrm{C} / \mathrm{W}$
N-20 DIP . . . . . . . . . . . . . . . . . . . . . . . $125^{\circ} \mathrm{C} / \mathrm{W}$
Operating Temperature Range
Commercial (J Version) . . . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . $65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature Soldering
Vapor Phase $\left(60 \mathrm{sec}\right.$ ) . . . . . . . . . . . . . . . . . . . . $+215^{\circ} \mathrm{C}$
Infrared ( 15 sec ) . . . . . . . . . . . . . . . . . . . . $+220^{\circ} \mathrm{C}$
ESD Rating . . . . . . . . . . . . . . . . . . . . . . $>2000 \mathrm{~V}$
*This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

## ORDERING GUIDE

| Model | Temperature Range | Package Option ${ }^{\star}$ |
| :--- | :--- | :--- |
| ADM202JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| ADM202JRN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{R}-16 \mathrm{~N}$ |
| ADM202JRW | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{R}-16 \mathrm{~W}$ |
| ADM203JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{N}-20$ |

[^227]PIN CONFIGURATIONS DIP/SOIC


DIP


*INTERNAL 400ks PULL-UP RESISTOR ON EACH TTL/CMOS INPUT **NTERNAL 5ks PULL-DOWN RESISTOR ON EACH RS-232 INPUT

Figure 1. Typical Operating Circuits

## PIN FUNCTION DESCRIPTION

| Mnemonic | Function |
| :---: | :---: |
| $\mathrm{V}_{\mathrm{cc}}$ | Power Supply Input $5 \mathrm{~V} \pm 10 \%$. |
| V+ | Internally Generated Positive Supply ( +10 V nominal). |
| V- | Internally Generated Negative Supply ( -10 V nominal). |
| GND | Ground Pin. Must be connected to 0 V . |
| C1+ | ADM202 External Capacitor, ( + terminal ) is connected to this pin. |
|  | ADM203: The capacitor is connected internally and no external capacitor is required. |
| C1- | ADM202 External Capacitor, ( - terminal) is connected to this pin. |
|  | ADM203: The capacitor is connected internally and no external capacitor is required. |
| C2+ | ADM202 External Capacitor, ( + terminal) is connected to this pin. |
|  | ADM203: The capacitor is connected internally and no external capacitor is required. |
| C2- | ADM202 External Capacitor, (-terminal) is connected to this pin. |
|  | ADM203: The capacitor is connected internally and no external capacitor is required. |
| $\mathrm{T}_{\text {IN }}$ | Transmitter (Driver) Inputs. These inputs accept TTL/CMOS levels. An internal $400 \mathrm{k} \Omega$ pull-up resistor to $\mathrm{V}_{\mathrm{CC}}$ is connected on each input. |
| $\mathrm{T}_{\text {OUT }}$ | Transmitter (Driver) Outputs. These are RS-232 levels (typically $\pm 10 \mathrm{~V}$ ). |


| $\mathrm{R}_{\mathrm{IN}}$ | Receiver Inputs. These inputs accept RS-232 signal levels. An internal $5 \mathrm{k} \Omega$ pull-down resistor to GND is connected <br> on each of these inputs. <br> Receiver Outputs. These are TTL/CMOS levels. |
| :--- | :--- |
| $\mathrm{R}_{\mathrm{OUT}}$ | R |

## GENERAL INFORMATION

The ADM202/ADM203 is an RS-232 drivers/receivers designed to solve interface problems by meeting the EIA-232E specifications while using a single digital +5 V supply. The EIA standard requires transmitters that will deliver $\pm 5 \mathrm{~V}$ minimum on the transmission channel and receivers that can accept signal levels down to $\pm 3 \mathrm{~V}$. The parts achieve this by integrating step up voltage converters and level shifting transmitters and receivers onto the same chip. CMOS technology is used to keep the power dissipation to an absolute minimum.
The ADM203 uses internal capacitors and, therefore, no external capacitors are required.
The ADM202 contains an internal voltage doubler and a voltage inverter which generates $\pm 10 \mathrm{~V}$ from the +5 V input. External $0.1 \mu \mathrm{~F}$ capacitors are required for the internal voltage converter.
The ADM202/ADM203 is a modification, enhancement and improvement to the AD230-AD241 family and derivatives thereof. It is essentially plug-in compatible and does not have materially different applications.

## CIRCUIT DESCRIPTION

The internal circuitry consists of three main sections. These are
(a) A Charge Pump Voltage Converter
(b) RS-232 to TTL/CMOS Receivers
(c) TTL/CMOS to RS-232 Transmitters

## Charge Pump DC-DC Voltage Converter

The charge pump voltage converter consists of an oscillator and a switching matrix. The converter generates a $\pm 10 \mathrm{~V}$ supply from the input 5 V level. This is done in two stages using a switched capacitor technique as illustrated below. First, the 5 V input supply is doubled to 10 V using capacitor Cl as the charge storage element. The 10 V level is then inverted to generate -10 V using C 2 as the storage element.
Capacitors C3 and C4 are used to reduce the output ripple. Their values are not critical and can be reduced if higher levels of ripple are acceptable. The charge pump capacitors C 1 and C 2 may also be reduced at the expense of higher output impedance on the $\mathrm{V}+$ and V - supplies. On the ADM203, all capacitors C 1 to C 4 are molded into the package.
The V+ and V- supplies may also be used to power external circuitry if the current requirements are small.

Figure 2. Charge Pump Voltage Doubler



Figure 3. Charge Pump Voltage Inverter

## Transmitter (Driver) Section

The drivers convert TTL/CMOS input levels into EIA-232-E output levels. With $\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V}$ and driving a typical EIA232 -E load, the output voltage swing is $\pm 9 \mathrm{~V}$. Even under worst case conditions the drivers are guaranteed to meet the $\pm 5 \mathrm{~V}$ EIA-232-E minimum requirement.
The input threshold levels are both TTL and CMOS compatible with the switching threshold set at $\mathrm{V}_{\mathrm{CC}} / 4$. With a nominal $\mathrm{V}_{\mathrm{CC}}$ $=5 \mathrm{~V}$ the switching threshold is 1.25 V typical. Unused inputs may be left unconnected, as an internal $400 \mathrm{k} \Omega$ pull-up resistor pulls them high forcing the outputs into a low state.
As required by the EIA-232-E standard the slew rate is limited to less than $30 \mathrm{~V} / \mu \mathrm{s}$ without the need for an external slew limiting capacitor and the output impedance in the power-off state is greater than $300 \Omega$.

## Receiver Section

The receivers are inverting level shifters that accept EIA-232-E input levels ( $\pm 5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$ ) and translate them into 5 V TTL/ CMOS levels. The inputs have internal $5 \mathrm{k} \Omega$ pull-down resistors to ground and are also protected against overvoltages of up to $\pm 30 \mathrm{~V}$. The guaranteed switching thresholds are 0.8 V minimum and 2.4 V maximum which are well within the $\pm 3 \mathrm{~V}$ EIA-232 requirement. The low level threshold is deliberately positive as it ensures that an unconnected input will be interpreted as a low level.
The receivers have Schmitt trigger input with a hysteresis level of 0.5 V . This ensures error free reception both for noisy inputs and for inputs with slow transition times.

FEATURES
$0.1 \mu \mathrm{~F}$ to $10 \mu \mathrm{~F}$ Capacitors
120 kB/s Data Rate
2 Receivers Active in Shutdown (ADM213)
On-Board DC-DC Converters
$\pm 9$ V Output Swing with +5 V Supply
Low Power ( 15 mW )
Low Power Shutdown $\leq 5 \mu \mathrm{~W}$
$\pm 30$ V Receiver Input Levels
Latch-Up FREE
Plug-In Upgrade for MAX205-211/213
APPLICATIONS
Computers
Peripherals
Modems
Printers
Instruments

## GENERAL DESCRIPTION

The ADM2xx family of line drivers/receivers is intended for all EIA-232-E and V. 28 communications interfaces, especially in applications where $\pm 12 \mathrm{~V}$ is not available. The ADM205, ADM206, ADM211 and ADM213 feature a low power shutdown mode which reduces power dissipation to less than $5 \mu \mathrm{~W}$ making them ideally suited for battery powered equipment. The ADM205 does not require any external components and is particularly useful in applications where printed circuit board space is critical. The ADM213 has an active-low shutdown and an active-high receiver enable control. Two receivers of the ADM213 remain active during shutdown. This feature is useful for ring indicator monitoring.

## TYPICAL OPERATING CIRCUIT


*INTERNAL 400ks PULL-UP RESISTOR ON EACH TTL/CMOS INPUT **INTERNAL 5kS PULL-DOWN RESISTOR ON EACH RS-232 INPUT

All members of the ADM2xx family, except the ADM209, include two internal charge pump voltage converters which allow operation from a single +5 V supply. These converters convert the +5 V input power to the $\pm 10 \mathrm{~V}$ required for RS-232 output levels. The ADM209 is designed to operate from +5 V and +12 V supplies. An internal +12 V to -12 V charge pump voltage converter generates the -12 V supply.

Table I. Selection Table

| Part | Power <br> Number | Supply Voltage | No. of <br> RS-232 <br> Drivers | No. of <br> RS-232 <br> Receivers | External <br> Capacitors | Low Power <br> Shutdown <br> (SD) | TTL <br> Three-State |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| EN |  |  |  |  |  |  |  | | No. of Receivers <br> Active in <br> Shutdown |
| :--- |
| ADM205 |
| (5 V |
| ADM206 |
| +5 V |

SDEG|F|GATONG $\begin{aligned} & V_{c c}=+5 V \pm 10 \% ~(206, ~ 207, ~ 208, ~\end{aligned}$
(ADM205); $V+=+9 V$ to +13.2 V (ADM209); C1-C4 $=0.1 \mu \mathrm{~F}$ Ceramic. All Specifications $\mathrm{T}_{\text {mIN }}$ to $\mathrm{T}_{\text {max }}$ unless otherwise noted.)

| Parameter | Min | Typ | Max | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Output Voltage Swing | $\pm 5$ | $\pm 9$ |  | Volts | All Transmitter Outputs Loaded with $3 \mathrm{k} \Omega$ to Ground |
| $\mathrm{V}_{\mathrm{CC}}$ Power Supply Current |  | 3 | 7 | mA | No Load, ADM206, ADM211, ADM213 |
|  |  | 5 | 9 | mA | No Load, ADM205, ADM207, ADM208 |
|  |  | 0.4 | 1 | mA | No Load, ADM209 |
| V+ Power Supply Current |  | 3.5 | 5 | mA | No Load, V+ = 12 V ADM209 Only |
| Shutdown Supply Current |  | 1 | 5 | $\mu \mathrm{A}$ |  |
| Input Logic Threshold Low, $\mathrm{V}_{\text {INL }}$ |  |  | 0.8 | V | $\mathrm{T}_{\text {IN }}, \overline{\mathrm{EN}}, \mathrm{SD}, \mathrm{EN}, \overline{\mathrm{SD}}$ |
| Input Logic Threshold High, $\mathrm{V}_{\text {INH }}$ | 2.0 |  |  | V | $\mathrm{T}_{\mathrm{IN}}, \overline{\mathrm{EN}}, \mathrm{SD}, \mathrm{EN}, \overline{\mathrm{SD}}$ |
| Logic Pull-Up Current |  | 10 | 25 | $\mu \mathrm{A}$ | $\mathrm{T}_{\mathrm{IN}}=0 \mathrm{~V}$ |
| RS-232 Input Voltage Range | -30 |  | +30 | V |  |
| RS-232 Input Threshold Low | 0.8 | 1.2 |  | V |  |
| RS-232 Input Threshold High |  | 1.7 | 2.4 | V |  |
| RS-232 Input Hysteresis | 0.2 | 0.5 | 1.0 | V |  |
| RS-232 Input Resistance | 3 | 5 | 7 | k ת |  |
| TTL/CMOS Output Voltage Low, $\mathrm{V}_{\text {OL }}$ |  |  | 0.4 | V | $\mathrm{I}_{\text {OUT }}=1.6 \mathrm{~mA}$ |
| TTL/CMOS Output Voltage High, $\mathrm{V}_{\mathrm{OH}}$ | 3.5 |  |  | V | $\mathrm{I}_{\text {OUT }}=-1.0 \mathrm{~mA}$ |
| TTL/CMOS Output Leakage Current |  | 0.05 | $\pm 5$ | $\mu \mathrm{A}$ | $\overline{\mathrm{EN}}=\mathrm{V}_{\mathrm{CC}}, \mathrm{EN}=0 \mathrm{~V}, 0 \mathrm{~V} \leq \mathrm{R}_{\text {OUT }} \leq \mathrm{V}_{\mathrm{CC}}$ |
| Output Enable Time ( $\mathrm{T}_{\mathrm{EN}}$ ) |  | 115 |  | ns | ADM205, ADM206, ADM209, ADM211 (Figure 25. $\mathrm{C}_{\mathrm{L}}=150 \mathrm{pF}$ ) |
| Output Disable Time ( $\mathrm{T}_{\text {DIS }}$ ) |  | 165 |  | ns | ADM205, ADM206, ADM209, ADM211 (Figure 25. $\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega$ ) |
| Propagation Delay |  | 0.5 | 5 | $\mu \mathrm{s}$ | RS-232 to TTL |
| Instantaneous Slew Rate ${ }^{1}$ |  | 25 | 30 | V/ $\mu \mathrm{s}$ | $\mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=3-7 \mathrm{k} \Omega, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |
| Transition Region Slew Rate | 3 | 6 |  | $\mathrm{V} / \mu \mathrm{s}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=3 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=2500 \mathrm{pF} \\ & \text { Measured from }+3 \mathrm{~V} \text { to }-3 \mathrm{~V} \text { or }-3 \mathrm{~V} \text { to }+3 \mathrm{~V} \end{aligned}$ |
| Output Resistance RS-232 Output Short Circuit Current | 300 | $\pm 12$ | $\pm 60$ | $\begin{aligned} & \Omega \\ & \mathrm{mA} \end{aligned}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{V}+=\mathrm{V}-=0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}= \pm 2 \mathrm{~V}$ |

## NOTE

${ }^{1}$ Sample tested to ensure compliance.
Specifications subject to change without notice.
ABSOLUTE MAXIMUM RATINGS*$\left(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right.$ unless otherwise noted)
$\mathrm{V}_{\mathrm{cc}}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . 0.3 V to +6 V
$\mathrm{V}+\ldots . . . . . . . . . . . . . . . . . . . . . .\left(\mathrm{V}_{\mathrm{CC}}-0.3 \mathrm{~V}\right)$ to +14 V
v- +0.3 V to -14 V
Input Voltages

$\mathrm{R}_{\text {IN }}$ ..... $\pm 30 \mathrm{~V}$
Output Voltages
Tout .....  (V+, + 0.3 V) to (V-, $-0.3 \mathrm{~V})$
$\mathrm{R}_{\text {out }}$ -0.3 V to $\left(\mathrm{V}_{\mathrm{cc}}+0.3 \mathrm{~V}\right)$
Short Circuit Duration
ToutPower Dissipation
N-24 DIP (Derate $13.5 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) . . . . 1000 mW
$\mathrm{N}-24 \mathrm{~A}$ DIP (Derate $13.5 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) ... 500 mW
R-24 SOIC (Derate $12 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) ..... 850 mW
R-28 SOIC (Derate $12.5 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) . . . 900 mW
RS-28 SSOP (Derate $10 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) .... 900 mWQ-24 Cerdip (Derate $12.5 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) . . 1000 mWD-24 Ceramic (Derate $20 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) . . 1000 mW

Thermal Impedance, $\theta_{\mathrm{JA}}$
N -24 DIP ..... $120^{\circ} \mathrm{C} / \mathrm{W}$
N-24A DIP ..... $110^{\circ} \mathrm{C} / \mathrm{W}$
R-24 SOIC ..... $85^{\circ} \mathrm{C} / \mathrm{W}$
R-28 SOIC ..... $80^{\circ} \mathrm{C} / \mathrm{W}$
RS-28 SSOP ..... $100^{\circ} \mathrm{C} / \mathrm{W}$
Q-14 Cerdip ..... $105^{\circ} \mathrm{C} / \mathrm{W}$
Q-16 Cerdip ..... $100^{\circ} \mathrm{C} / \mathrm{W}$
Q-20 Cerdip ..... $100^{\circ} \mathrm{C} / \mathrm{W}$
Q-24 Cerdip ..... $55^{\circ} \mathrm{C} / \mathrm{W}$
D-24 Ceramic ..... $50^{\circ} \mathrm{C} / \mathrm{W}$
Operating Temperature RangeIndustrial (A Version)$-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature, Soldering ..... $+300^{\circ} \mathrm{C}$
Vapour Phase ( 60 sec ) ..... $+215^{\circ} \mathrm{C}$
Infrared ( 15 sec ) ..... $+220^{\circ} \mathrm{C}$
ESD Rating ..... $>2000 \mathrm{~V}$
$\star$ This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

## ORDERING GUIDE

| Model | Temperature Range | Package Option* | Model | Temperature Range | Package Option ${ }^{\star}$ | Model | Temperature Range | Package Option ${ }^{\star}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ADM205 |  |  | ADM206 |  |  | ADM207 |  |  |
| ADM205AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | N-24A | ADM206AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | N-24 | ADM207AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-24$ |
|  |  |  | ADM206AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | R-24 | ADM207AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | R-24 |
|  |  |  | ADM206ARS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | RS-24 | ADM207ARS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | RS-24 |
| ADM208 |  |  | ADM209 |  |  | ADM211 |  |  |
| ADM208AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | N-24 | ADM209AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | N-24 | ADM211AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | R-28 |
| ADM208AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | R-24 | ADM209AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | R-24 | ADM211ARS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | RS-28 |
| ADM208ARS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | RS-24 | ADM209ARS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | RS-24 |  |  |  |
| ADM213 |  |  |  |  |  |  |  |  |
| ADM213AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | R-28 |  |  |  |  |  |  |
| ADM213ARS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | RS-28 |  |  |  |  |  |  |

${ }^{\star} \mathrm{N}=$ Plastic DIP; R = Small Outline IC (SOIC); RS = Small Shrink Outline Package (SSOP). For outline information see Package Information section.


Figure 1. ADM205 DIP Pin Configuration

*INTERNAL 400ks PULL-UP RESISTOR ON EACH TTL/CMOS INPUT **NTERNAL 5k $\Omega$ PULL-DOWN RESISTOR ON EACH RS-232 INPUT

Figure 2. ADM205 Typical Operating Circuit


Figure 3. ADM206 DIP/SOIC/SSOP Pin Configuration


Figure 4. ADM206 Typical Operating Circuit


Figure 5. ADM207 DIP/SOIC/SSOP Pin Configuration


Figure 7. ADM208 DIP/SOIC/SSOP Pin Configuration


Figure 8. ADM208 Typical Operating Circuit


Figure 9. ADM209 DIP/SOIC/SSOP Pin Configuration



Figure 11. ADM211 SOIC/SSOP Pin Configuration


Figure 12. ADM211 Typical Operating Circuit


Figure 13. ADM213 SOIC/SSOP Pin Configuration


Figure 14. ADM213 Typical Operating Circuit

PIN FUNCTION DESCRIPTION

| Mnemonic | Function |
| :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | Power Supply Input $5 \mathrm{~V} \pm 10 \%$ ( $+5 \mathrm{~V} \pm 5 \%$ ADM205). |
| V+ | Internally generated positive supply ( +10 V nominal) on all parts except ADM209. |
|  | ADM209 requires external 9 V to 13.2 V supply. |
| V- | Internally generated negative supply ( -10 V nominal). |
| GND | Ground pin. Must be connected to 0 V . |
| C+ | (ADM209 only) External capacitor (+ terminal) is connected to this pin. |
| C- | (ADM209 only) External capacitor (- terminal) is connected to this pin. |
| C1+ | (ADM206, ADM207, ADM208, ADM211, ADM213) External capacitor (+ terminal) is connected to this pin. |
| C1- | (ADM206, ADM207, ADM208, ADM211, ADM213) External capacitor (- terminal) is connected to this pin. |
| C2+ | (ADM206, ADM207, ADM208, ADM211, ADM213) External capacitor (+ terminal) is connected to this pin. |
| C2- | (ADM206, ADM207, ADM208, ADM211, ADM213) External capacitor (- terminal) is connected to this pin. |
| $\mathrm{T}_{\text {IN }}$ | Transmitter (Driver) Inputs. These inputs accept TTL/CMOS levels. An internal $400 \mathrm{k} \Omega$ pull-up resistor to $\mathrm{V}_{\mathrm{CC}}$ is connected on each input. |
| $\mathrm{T}_{\text {OUT }}$ | Transmitter (Driver) Outputs. These are RS-232 levels (typically $\pm 10 \mathrm{~V}$ ). |
| $\mathrm{R}_{\text {IN }}$ | Receiver Inputs. These inputs accept RS-232 signal levels. An internal $5 \mathrm{k} \Omega$ pull-down resistor to GND is connected on each input. |
| $\mathrm{R}_{\text {OUT }}$ | Receiver Outputs. These are TTL/CMOS levels. |
| $\overline{\mathrm{EN} / \mathrm{EN}}$ | Enable Input. Active low on ADM205, ADM206, ADM209, ADM211. Active high on ADM213. This input is used to enable/disable the receiver outputs. With $\overline{\mathrm{EN}}=\mathrm{Low}(\mathrm{EN}=$ High ADM213), the receiver outputs are enabled. With $\overline{\mathrm{EN}}=\mathrm{High}(\mathrm{EN}=$ low ADM213), the outputs are placed in a high impedance state. This facility is useful for connecting to microprocessor systems. |
| SD/ $/ \overline{\text { SD }}$ | Shutdown Input. Active high on ADM205, ADM206, ADM211. Active low on ADM213. With $\mathrm{SD}=$ high on the ADM205, ADM206, ADM211, the charge pump is disabled, the receiver outputs are placed in a high impedance state and the driver outputs are turned off. With $\overline{\mathrm{SD}}$ low on the ADM213, the charge pump is disabled, the driver outputs are turned off and all receivers except R4 and R5 are placed in a high impedance state. In shutdown, the power consumption reduces to $5 \mu \mathrm{~W}$. |
| NC | No Connect. No connections are required to this pin. |

Table II. ADM205, ADM206, ADM211 Truth Table

| SD | $\overline{\mathbf{E N}}$ | Status | Transmitters T1-T5 | Receivers R1-R5 |
| :--- | :--- | :--- | :---: | :---: |
| 0 | 0 | Normal Operation | Enabled | Enabled |
| 0 | 1 | Normal Operation | Enabled | Disabled |
| 1 | 0 | Shutdown | Disabled | Disabled |

Table III. ADM213 Truth Table

| $\overline{\text { SD }}$ | EN | Status | Transmitters T1-T4 | Receivers R1-R3 | Receivers R4, R5 |
| :--- | :--- | :--- | :---: | :---: | :---: |
| 0 | 0 | Shutdown | Disabled | Disabled | Disabled |
| 0 | 1 | Shutdown | Disabled | Disabled | Enabled |
| 1 | 0 | Normal Operation | Enabled | Disabled | Disabled |
| 1 | 1 | Normal Operation | Enabled | Enabled | Enabled |

## Typical Performance Characteristics



Figure 15. Charge Pump V+, V- vs. Current


Figure 16. Transmitter Slew Rate vs. Load Capacitance


Figure 17. Transmitter Output Voltage vs. $V_{C C}$


Figure 18. Transmitter Output Voltage vs. Current


Figure 19. Charge Pump Impedance vs. $V_{C C}$


Figure 20. Charge Pump, V+,V-Exiting Shutdown


Figure 21. Transmitter Output Loaded Slew Rate


Figure 22. Transmitter Output Unloaded Slew Rate

## GENERAL INFORMATION

The ADM205-ADM211 and ADM213 family of RS-232 drivers/ receivers are designed to solve interface problems by meeting the EIA-232-E specifications while using a single digital +5 V supply. The EIA-232-E standard requires transmitters which will deliver $\pm 5 \mathrm{~V}$ minimum on the transmission channel and receivers which can accept signal levels down to $\pm 3 \mathrm{~V}$. The ADM205-ADM211 and ADM213 meet these requirements by integrating step up voltage converters and level shifting transmitters and receivers onto the same chip. CMOS technology is used to keep the power dissipation to an absolute minimum. A comprehensive range of transmitter/receiver combinations is available to cover most communications needs. The ADM205ADM211 and ADM213 are modifications, enhancements and improvements to the AD230-AD241 family and derivatives thereof. They are essentially plug-in compatible and do not have materially different applications.
The ADM205, ADM206, ADM211, and ADM213 are particularly useful in battery powered systems as they feature a low
power shutdown mode which reduces power dissipation to less than $5 \mu \mathrm{~W}$.
The ADM205 is designed for applications where space saving is important as the charge pump capacitors are molded into the package.
The ADM209 includes only a negative charge pump converter and are intended for applications where a positive 12 V is available.

To facilitate sharing a common line or for connection to a microprocessor data bus the ADM205, ADM206, ADM209, ADM211 and ADM213 feature an enable ( $\overline{\mathrm{EN}})$ function. When disabled, the receiver outputs are placed in a high impedance state.

## CIRCUIT DESCRIPTION

The internal circuitry in the ADM205-ADM211 and ADM213 consists of three main sections. These are:
(a) A charge pump voltage converter
(b) RS-232 to TTL/CMOS receivers
(c) TTL/CMOS to RS-232 transmitters

## Charge Pump DC-DC Voltage Converter

The charge pump voltage converter consists of an oscillator and a switching matrix. The converter generates a $\pm 10 \mathrm{~V}$ supply from the input 5 V level. This is done in two stages using a switched capacitor technique as illustrated in Figures 23 and 24. First, the 5 V input supply is doubled to 10 V using capacitor Cl as the charge storage element. The 10 V level is then inverted to generate -10 V using C 2 as the storage element.


Figure 23. Charge-Pump Voltage Doubler


Figure 24. Charge-Pump Voltage Inverter
Capacitors C3 and C4 are used to reduce the output ripple. Their values are not critical and can be reduced if higher levels of ripple are acceptable. The charge pump capacitors C 1 and C 2 may also be reduced at the expense of higher output impedance on the $\mathrm{V}+$ and V - supplies.
The V+ and V- supplies may also be used to power external circuitry if the current requirements are small.

## Transmitter (Driver) Section

The drivers convert TTL/CMOS input levels into EIA-232-E output levels. With $\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V}$ and driving a typical EIA-$232-\mathrm{E}$ load, the output voltage swing is $\pm 9 \mathrm{~V}$. Even under worst case conditions the drivers are guaranteed to meet the $\pm 5 \mathrm{~V}$ EIA-232-E minimum requirement.
The input threshold levels are both TTL and CMOS compatible with the switching threshold set at $\mathrm{V}_{\mathrm{CC}} / 4$. With a nominal $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$ the switching threshold is 1.25 V typical. Unused inputs may be left unconnected, as an internal $400 \mathrm{k} \Omega$ pull-up resistor pulls them high forcing the outputs into a low state.

As required by the EIA-232-E standard, the slew rate is limited to less than $30 \mathrm{~V} / \mu \mathrm{s}$ without the need for an external slew limiting capacitor and the output impedance in the power-off state is greater than $300 \Omega$.

## Receiver Section

The receivers are inverting level shifters which accept EIA-$232-\mathrm{E}$ input levels ( $\pm 5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$ ) and translate them into 5 V TTL/CMOS levels. The inputs have internal $5 \mathrm{k} \Omega$ pull-down resistors to ground and are also protected against overvoltages of up to $\pm 30 \mathrm{~V}$. The guaranteed switching thresholds are 0.8 V minimum and 2.4 V maximum which are well within the $\pm 3 \mathrm{~V}$ EIA-232-E requirement. The low level threshold is deliberately positive as it ensures that an unconnected input will be interpreted as a low level.
The receivers have Schmitt trigger inputs with a hysteresis level of 0.5 V . This ensures error-free reception for both noisy inputs and for inputs with slow transition times.

## Shutdown (SD)

The ADM205, ADM206, ADM211 and ADM213 feature a control input which may be used to disable the part and reduce the power consumption to less than $5 \mu \mathrm{~W}$. This is very useful in battery operated systems. During shutdown the charge pump is turned off, the transmitters are disabled and all receivers except R4 and R5 on the ADM213 are put into a high-impedance disabled state. Receivers R4 and R5 on the ADM213 remain enabled during shutdown. This feature allows monitoring external activity such as ring indicator monitoring while the device is in a low power shutdown mode. The shutdown control input is active high on all parts except the ADM213 where it is active low. Refer to Tables II and III.

## Enable Input

The ADM205, ADM209, ADM211, and ADM213 feature an enable input used to enable or disable the receiver outputs. The enable input is active low on the ADM205, ADM209, ADM211 and active-high on the ADM213. Refer to Tables II and III. When disabled, all receiver outputs are placed in a high impedance state. This function allows the outputs to be connected directly to a microprocessor data bus. It can also be used to allow receivers from different devices to share a common data line. The timing diagram for the enable function is shown in Figure 25.


Figure 25. Enable Timing

## APPLICATION HINTS

## Driving Long Cables

In accordance with the EIA-232-E standard, long cables are permissible provided that the total load capacitance does not exceed 2500 pF . For longer cables which do exceed this, then it is possible to trade off baud rate vs. cable length. Large load capacitances cause a reduction in slew rate, and hence the maximum transmission baud rate is decreased. The ADM205-ADM211 and ADM213 are designed so that the slew rate reduction with increasing load capacitance is minimized.
For the receivers, it is important that a high level of noise immunity be inbuilt so that slow rise and fall times do not cause multiple output transitions as the signal passes slowly through the transition region. The ADMZ05-ADM211 and ADM213 have 0.5 V of hysteresis to guard against this. This ensures that, even in noisy environments, error-free reception can be achieved.

## High Baud Rate Operation

The ADM205-ADM211 and ADM213 feature high slew rates permitting data transmission at rates well in excess of the EIA232 -E specification. The drivers maintain $\pm 5 \mathrm{~V}$ signal levels at data rates up to $120-\mathrm{kB} / \mathrm{s}$ under worst-case loading conditions.

## FEATURES

200 kB/s Transmission Rate
Small ( $0.1 \mu$ F) Charge Pump Capacitors
Single 5 V Power Supply
Meets All EIA-232-E and V. 28 Specifications
Two Drivers and Two Receivers
On-Board DC-DC Converters
$\pm 9$ V Output Swing with +5 V Supply $\pm 30$ V Receiver Input Levels
Pin Compatible with MAX222/MAX232A/MAX242

## APPLICATIONS

Computers
Peripherals
Modems
Printers
Instruments

## GENERAL DESCRIPTION

The ADM222, ADM232A, ADM242 are a family of high speed RS-232 line drivers/receivers offering transmission rates up to $200 \mathrm{kB} / \mathrm{s}$. Operating from a single +5 V power supply, a highly efficient on-chip charge pump using small $(0.1 \mu \mathrm{~F})$ external capacitors allows RS-232 bipolar levels to be developed. Two RS-232 drivers and two RS-232 receivers are provided on each device.
The devices are fabricated on BiCMOS , an advanced mixed technology process which combines low power CMOS with high speed bipolar circuitry. This allows for transmission rates up to $200 \mathrm{kB} / \mathrm{s}$ yet minimizes the quiescent power supply current to under 5 mA .
The ADM232A is a pin-compatible, high speed upgrade for the AD232 and for the ADM232L. It is available in 16-pin DIP and in both narrow and wide surface mount (SOIC) packages.
The ADM222 contains an additional shutdown ( $\overline{\mathrm{SHDN}}$ ) function which may be used to disable the device thereby reducing the supply current to $0.1 \mu \mathrm{~A}$. During shutdown, all transmit/ receive functions are disabled. The ADM222 is available in 18 -pin DIP and in a wide surface mount (SOIC) package.
The ADM242 combines both shutdown ( $\overline{\mathrm{SHDN}}$ ) and enable $(\overline{\mathrm{EN}})$ functions. The shutdown function reduces the supply curent to 0.1 mA . During shutdown, the transmitters are disabled but the receivers continue to operate normally. The enable function allows the receiver outputs to be disabled thereby facilitating sharing a common bus.' The ADM242 is available in 18 -pin DIP and in a wide surface mount (SOIC) package.

[^228]FUNCTIONAL BLOCK DIAGRAM


ORDERING GUIDE

| Model | Temperature Range | Package Option |
| :--- | :--- | :--- |
| ADM222AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-18$ |
| ADM222AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-18 \mathrm{~W}$ |
| ADM232AAN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| ADM232AARN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16 \mathrm{~N}$ |
| ADM232AARW | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16 \mathrm{~W}$ |
| ADM242AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-18$ |
| ADM242AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-18 \mathrm{~W}$ |

[^229]| Parameter | Min | Typ | Max | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| RS-232 TRANSMITTERS <br> Output Voltage Swing <br> Input Logic Threshold Low, $\mathrm{V}_{\text {INL }}$ <br> Input Logic Threshold High, $\mathrm{V}_{\text {INH }}$ <br> Logic Pullup Current <br> Data Rate <br> Output Resistance <br> Output Short Circuit Current (Instantaneous) | $\begin{aligned} & \pm 5 \\ & \\ & 2.0 \\ & \\ & 200 \\ & 300 \\ & \pm 7 \end{aligned}$ | $\begin{aligned} & \pm 9 \\ & \\ & 1.4 \\ & 1.4 \\ & 5 \\ & \\ & \pm 22 \end{aligned}$ | 0.8 40 | V <br> V <br> V <br> $\mu \mathrm{A}$ <br> kB/s <br> $\Omega$ <br> mA | All Transmitter Outputs Loaded with $3 \mathrm{k} \Omega$ to Ground <br> $\mathrm{T}_{\mathrm{IN}}$ <br> $\mathrm{T}_{\mathrm{IN}}$ <br> $\mathrm{T}_{\mathrm{IN}}=0 \mathrm{~V}$ $\mathrm{V}_{\mathrm{CC}}=\mathrm{V}+=\mathrm{V}-=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{OUT}}= \pm 2 \mathrm{~V}$ |
| RS-232 RECEIVERS <br> RS-232 Input Voltage Range <br> RS-232 Input Threshold Low <br> RS-232 Input Threshold High <br> RS-232 Input Hysteresis <br> RS-232 Input Resistance <br> TTL/CMOS Output Voltage Low, $\mathrm{V}_{\text {OL }}$ <br> TTL/CMOS Output Voltage High, $\mathrm{V}_{\mathrm{OH}}$ <br> TTL/CMOS Output Short-Circuit Current <br> TTL/CMOS Output Short-Circuit Current <br> TTL/CMOS Output Leakage Current <br> $\overline{\text { EN }}$ Input Threshold Low, $\mathrm{V}_{\text {INL }}$ <br> $\overline{\text { EN }}$ Input Threshold High, $\mathrm{V}_{\text {INH }}$ | $\begin{aligned} & -30 \\ & 0.8 \\ & 0.2 \\ & 3 \\ & 3.5 \\ & -2 \\ & 10 \\ & \\ & \hline 2.0 \\ & \hline \end{aligned}$ | $\begin{aligned} & 1.3 \\ & 1.8 \\ & 0.5 \\ & 5 \\ & 0.2 \\ & \\ & -10 \\ & 30 \\ & \pm 0.05 \\ & \\ & 1.4 \\ & 1.4 \\ & \hline \end{aligned}$ | $+30$ <br> 2.4 <br> 1.0 <br> 7 <br> 0.4 $\begin{aligned} & \pm 10 \\ & 0.8 \end{aligned}$ | V <br> V <br> V <br> V <br> k $\Omega$ <br> V <br> V <br> mA <br> mA <br> $\mu \mathrm{A}$ <br> V <br> V | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{OUT}}=3.2 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OUT}}=-1.0 \mathrm{~mA} \\ & \text { Source Current }\left(\mathrm{V}_{\mathrm{OUT}}=\mathrm{GND}\right) \\ & \text { Sink Current }\left(\mathrm{V}_{\mathrm{OUT}}=\mathrm{V}_{\mathrm{CC}}\right) \\ & \hline \text { SHDN }=\mathrm{GND} / \overline{\mathrm{EN}}=\mathrm{V}_{\mathrm{CC}} \\ & 0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{OUT}} \leq \mathrm{V}_{\mathrm{CC}} \end{aligned}$ |
| POWER SUPPLY <br> Power Supply Current <br> Shutdown Power Supply Current <br> SHDN Input Leakage Current <br> SHDN Input Threshold Low, $\mathrm{V}_{\text {INL }}$ <br> SHDN Input Threshold High, $\mathrm{V}_{\text {INH }}$ | 2.0 | 4 <br> 15 <br> 0.1 <br> 1.4 <br> 1.4 | $\begin{aligned} & 8 \\ & \\ & 10 \\ & \pm 1 \\ & 0.8 \end{aligned}$ | mA <br> mA <br> $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ <br> V <br> V | No Load $3 \mathrm{k} \Omega$ Load on Both Outputs |
| AC CHARACTERISTICS <br> Transition Region Slew Rate <br> Transmitter Propagation Delay TTL to RS-232 <br> Receiver Propagation Delay RS-232 to TTL <br> Receiver Output Enable Time Receiver Output Disable Time Transmitter Output Enable Time Transmitter Output Disable Time Transmitter + to - Propagation Delay Difference Receiver + to - Propagation Delay Difference | 6 | 12 <br> 0.7 <br> 0.7 <br> 0.2 <br> 0.3 <br> 125 <br> 160 <br> 250 <br> 3.5 <br> 300 <br> 100 | $\begin{aligned} & 30 \\ & 3.5 \\ & 3.5 \\ & 0.5 \\ & 0.5 \\ & 500 \\ & 500 \end{aligned}$ | $\mathrm{V} / \mu \mathrm{s}$ <br> $\mu \mathrm{s}$ $\mu \mathrm{s}$ $\mu \mathrm{s}$ $\mu \mathrm{s}$ ns ns $\mu \mathrm{s}$ $\mu \mathrm{s}$ ns ns | $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ to $2500 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=3 \mathrm{k} \Omega$ to $7 \mathrm{k} \Omega$ <br> Measured from +3 V to -3 V or -3 V to +3 V <br> $\mathrm{t}_{\text {PHLT }}$ <br> $\mathrm{t}_{\text {PLHT }}$ <br> $\mathrm{t}_{\text {PHLR }}$ <br> $\mathrm{t}_{\text {PLHR }}$ <br> $\mathrm{t}_{\mathrm{ER}}$ <br> $\mathrm{t}_{\mathrm{DR}}$ <br> SHDN Goes high <br> SHDN Goes low |

Specifications subject to change without notice.

## ADM222/ADM232A/ADM242

ABSOLUTE MAXIMUM RATINGS*

| ( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted) |  |
| :---: | :---: |
| $\mathrm{V}_{\mathrm{Cc}}$ | $+6 \mathrm{~V}$ |
| V+ | . $\left(\mathrm{V}_{\mathrm{CC}}-0.3 \mathrm{~V}\right)$ to +13 V |
| V- | . +0.3 V to -13 V |
| Input Voltages |  |
| $\mathrm{T}_{\text {IN }}$ | -0.3 V to $\left(\mathrm{V}_{\mathrm{CC}}+0.3 \mathrm{~V}\right)$ |
| $\mathrm{R}_{\text {IN }}$ | $\pm 30 \mathrm{~V}$ |


| Output Voltages |  |
| :---: | :---: |
| $\mathrm{T}_{\text {out }}$ | $(\mathrm{V}+,+0.3 \mathrm{~V})$ to ( $\mathrm{V}-,-0.3 \mathrm{~V}$ ) |
| $\mathrm{R}_{\text {OUT }}$ | -0.3 V to $\left(\mathrm{V}_{\mathrm{CC}}+0.3 \mathrm{~V}\right)$ |


| Short Circuit Duration |  |
| :---: | :---: |
| $\mathrm{T}_{\text {out }}$ | Continuous |
| Power Dissipation N-16 . . . . . . . . . . . . . . . . . . . . . . . 400 mW (Derate $7.5 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) |  |
|  |  |
| $\theta_{\text {JA }}$, Thermal Impedance | $80^{\circ} \mathrm{C} / \mathrm{W}$ |
| Power Dissipation R-16N .......................... . 400 mW <br> (Derate $7 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) |  |
|  |  |
| $\theta_{\mathrm{JA}}$, Thermal Impedance | $80^{\circ} \mathrm{C} / \mathrm{W}$ |

## Test Circuits



Figure 1. Transmitter Propagation Delay Timing

Figure 2. Receiver Enable Timing


| Power Dissipation R-16W . . . . . . . . . . . . . . . . . . 400 mW |  |
| :---: | :---: |
| $\theta_{\text {IA }}$, Thermal Impedance | $80^{\circ} \mathrm{C} / \mathrm{W}$ |
| Power Dissipation N-18 . . . . . . . <br> (Derate $7 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) | 400 mW |
| $\theta_{\text {IA }}$, Thermal Impedance | $80^{\circ} \mathrm{C} / \mathrm{W}$ |
| Power Dissipation R-18W ....... <br> (Derate $7 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) | $400 \mathrm{~mW}$ |
|  | W |
| Operating Temperature Range |  |
| Industrial (A Version) | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Storage Temperature Range . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |  |
| Lead Temperature (Soldering, 10 sec ) | $+300^{\circ} \mathrm{C}$ |
| Vapor Phase (60 sec) | $+215^{\circ} \mathrm{C}$ |
| Infrared (15 sec) | $+220^{\circ} \mathrm{C}$ |

*This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.


Figure 3. Receiver Propagation Delay Timing


Figure 4. Receiver Disable Timing


Figure 5. Shutdown Test Circuit


Figure 6. Transmitter Shutdown Disable Timing


Figure 7. ADM222 Typical Operating Circuit

## PIN FUNCTION DESCRIPTION

| Mnemonic | Function |
| :---: | :---: |
| $\mathbf{V}_{\text {CC }}$ | Power Supply Input, $+5 \mathrm{~V} \pm 10 \%$. |
| V+ | Internally generated positive supply ( +10 V nominal). |
| V- | Internally generated negative supply ( -10 V nominal). |
| GND | Ground Pin. Must be connected to 0 V . |
| $\mathrm{C} 1+$ | External capacitor 1, (+ terminal) is connected to this pin. |
| C1- | External capacitor 1, (- terminal) is connected to this pin. |
| C2+ | External capacitor 2, (+ terminal) is connected to this pin. |
| C2- | External capacitor 2, (- terminal) is connected to this pin. |
| $\mathrm{T}_{\text {IN }}$ | Transmitter (Driver) Inputs. These inputs accept TTL/CMOS levels. An internal $400 \mathrm{k} \Omega$ pull-up resistor to $\mathrm{V}_{\mathrm{CC}}$ is connected on each input. |
| $\mathrm{T}_{\text {OUT }}$ | Transmitter (Driver) Outputs. These are RS-232 levels (typically $\pm 9 \mathrm{~V}$ ). |
| $\mathrm{R}_{\text {IN }}$ | Receiver Inputs. These inputs accept RS-232 signal levels. An internal $5 \mathrm{k} \Omega$ pull-down resistor to GND is connected on each of these inputs. |
| $\mathrm{R}_{\text {OUT }}$ | Receiver Outputs. These are TTL/CMOS levels. |
| NC | No Connect. No connections are required to this pin. |
| $\overline{\mathrm{EN}}$ | (ADM242 Only) Active Low Digital Input. May be used to enable or disable (three-state) both receiver outputs. |
| $\overline{\text { SHDN }}$ | (ADM222 \& ADM242) Active Low Digital | the power consumption is minimized. On the ADM222 all drivers and receivers are disabled. On the ADM242 the drivers are disabled but the receivers remain enabled.



Figure 8. ADM222 DIP \& SOIC Pin Configurations


Figure 9. ADM232A DIP/SOIC Pin Configuration


Figure 10. ADM232A Typical Operating Circuit


Figure 11. ADM242 DIP/SOIC Pin Configuration


Figure 12. ADM242 Typical Operating Circuit

## Typical Performance Characteristics-ADM222/ADM232A/ADM242



Figure 13. Charge Pump V+, V-vs. Current


Figure 14. Transmitter Baud Rate vs. Load Capacitance


Figure 15. Transmitter Unloaded Slew Rate


Figure 16. Transmitter Output Voltage vs. Current


Figure 17. Charge Pump V+, V-Exiting Shutdown


Figure 18. Transmitter Fully Loaded Slew Rate

## ADM222/ADM232A/ADM242

## GENERAL INFORMATION

The ADM222/ADM232A/ADM242 are high speed RS-232 drivers/receivers requiring a single digital +5 V supply. The RS232 standard requires transmitters that will deliver $\pm 5 \mathrm{~V}$ minimum on the transmission channel and receivers that can accept signal levels down to $\pm 3 \mathrm{~V}$. The parts achieve this by integrating step up voltage converters and level shifting transmitters and receivers onto the same chip. CMOS technology is used to keep the power dissipation to an absolute minimum. All devices contains an internal charge pump voltage doubler and a voltage inverter that generates $\pm 10 \mathrm{~V}$ from the +5 V input. Four external $0.1 \mu \mathrm{~F}$ capacitors are required for the internal charge pump voltage converter.
The ADM222/ADM232A/ADM242 is a modification, enhancement and improvement to the AD230-AD241 family and derivatives thereof. It is essentially plug-in compatible and does not have materially different applications.

## CIRCUIT DESCRIPTION

The internal circuitry consists of four main sections. These are:
A Charge Pump Voltage Converter
TTL/CMOS to RS-232 Transmitters
RS-232 to TTL/CMOS Receivers
Enable and Shutdown Functions.

## Charge Pump DC-DC Voltage Converter

The Charge Pump Voltage converter consists of an oscillator and a switching matrix. The converter generates a $\pm 10 \mathrm{~V}$ supply from the input 5 V level. This is done in two stages using a switched capacitor technique. The 5 V input supply is doubled to 10 V using capacitor C 1 as the charge storage element. The -10 V level is also generated from the input 5 V supply using C 1 and C 2 as the storage elements.
Capacitors C3 and C4 are used to reduce the output ripple. Their values are not critical and can be reduced if higher levels of ripple are acceptable. The charge pump capacitors Cl and C 2 may also be reduced at the expense of higher output impedance on the $\mathrm{V}+$ and V - supplies.

The V+ and V - supplies may also be used to power external circuitry if the current requirements are small. Please refer to the typical performance characteristics which shows the $\mathrm{V}+, \mathrm{V}-$ output voltage vs. current.
In the shutdown mode the charge pump is disabled and $\mathrm{V}+$ decays to $\mathrm{V}_{\mathrm{CC}}$ while V - decays to 0 V .

Transmitter (Driver) Section
The Drivers convert TTL/CMOS input levels into RS-232 output levels. With $\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V}$ and driving a typical RS-232 load, the output voltage swing is $\pm 9 \mathrm{~V}$. Even under worst case conditions the drivers are guaranteed to meet the $\pm 5 \mathrm{~V}$ RS-232 minimum requirement.

The input threshold levels are both TTL and CMOS compatible with the switching threshold set at $\mathrm{V}_{\mathrm{CC}} / 4$. With a nominal $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$ the switching threshold is 1.25 V typical. Unused inputs may be left unconnected, as an internal $400 \mathrm{k} \Omega$ pull- up resistor pulls them high forcing the outputs into a low state.

As required by the RS-232 standard, the slew rate is limited to less than $30 \mathrm{~V} / \mu \mathrm{s}$ without the need for an external slew limiting capacitor, and the output impedance in the power-off state is greater than $300 \Omega$.

## Receiver Section

The receivers are inverting level shifters which accept RS-232 input levels ( $\pm 3 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$ ) and translate them into 5 V TTL/ CMOS levels. The inputs have internal $5 \mathrm{k} \Omega$ pull-down resistors to ground and are also protected against overvoltages of up to $\pm 30 \mathrm{~V}$. The guaranteed switching thresholds are 0.8 V minimum and 2.4 V maximum which are well within the $\pm 3 \mathrm{~V}$ RS232 requirement. The low level threshold is deliberately positive as it ensures that an unconnected input will be interpreted as a low level.

The receivers have Schmitt trigger input with a hysteresis level of 0.5 V . This ensures error free-reception for both noisy inputs and for inputs with slow transition times

## Enable and Shutdown Functions

On the ADM222, both receivers are fully disabled during shutdown.

On the ADM242, both receivers continue to operate normally. This function is useful for monitoring activity so that when it occurs, the device can be taken out of the shutdown mode.
The ADM242 also contains a receiver enable function ( $\overline{\mathrm{EN}})$ which can be used to fully disable the receivers, independent of SHDN.

## APPLICATIONS INFORMATION

A selection of typical operating circuits is shown in Figures 13 to 19 .


Figure 19. Transmitter Output Disable Timing

## +5 V Powered CMOS RS-232 Drivers/Receivers

 ADM223/ADM230L-ADM241L
## FEATURES

Single 5 V Power Supply
Meets All EIA-232-E and V. 28 Specifications 120 kB/s Data Rate
On-Board DC-DC Converters
$\pm 9$ V Output Swing with +5 V Supply
Small $1 \mu \mathrm{~F}$ Capacitors
Low Power Shutdown $\leq 1 \mu \mathrm{~A}$
Receivers Active in Shutdown (ADM223)
ESD > 2 kV
$\pm 30$ V Receiver Input Levels
Latch-Up FREE
Plug-In Upgrade for MAX223/230-241
Plug-In Upgrade for AD230-AD241

## APPLICATIONS

Computers
Peripherals
Modems
Printers
Instruments

## GENERAL DESCRIPTION

The ADM2xx family of line drivers/receivers is intended for all EIA-232-E and V. 28 communications interfaces, especially in applications where $\pm 12 \mathrm{~V}$ is not available. The ADM223, ADM230L, ADM235L, ADM236L and ADM241L feature a low power shutdown mode which reduces power dissipation to less than $5 \mu \mathrm{~W}$ making them ideally suited for battery powered equipment. Two receivers remain enabled during shutdown on the ADM223. The ADM233L and ADM235L do not require any external components and are particularly useful in applications where printed circuit board space is critical.

## ADM232L TYPICAL OPERATING CIRCUIT



All members of the ADM230L family, except the ADM231L and the ADM239L, include two internal charge pump voltage converters which allow operation from a single +5 V supply. These converters convert the +5 V input power to the $\pm 10 \mathrm{~V}$ required for RS-232 output levels. The ADM231L and ADM239L are designed to operate from +5 V and +12 V supplies. An internal +12 V to -12 V charge pump voltage converter generates the -12 V supply.
The ADM2xxL is an enhanced upgrade for the AD2xx family featuring lower power consumption, faster slew rate and operation with smaller ( $1 \mu \mathrm{~F}$ ) capacitors.

Table I. Selection Table
$\left.\begin{array}{l|l|l|l|l|l|l|l}\hline \begin{array}{l}\text { Part } \\ \text { Number }\end{array} & \begin{array}{l}\text { Power } \\ \text { Supply Voltage }\end{array} & \begin{array}{l}\text { No. of } \\ \text { RS-232 } \\ \text { Drivers }\end{array} & \begin{array}{l}\text { No. of } \\ \text { RS-232 } \\ \text { Receivers }\end{array} & \begin{array}{l}\text { External } \\ \text { Capacitors }\end{array} & \begin{array}{l}\text { Low Power } \\ \text { Shutdown } \\ \text { (SD) }\end{array} & \begin{array}{l}\text { TTL } \\ \text { Three-State }\end{array} \\ \hline \text { EN }\end{array} \begin{array}{l}\text { No. of } \\ \text { Pins }\end{array}\right]$
 $+5 \mathrm{~V} \pm 5 \%$ (ADM230L, 33L, 35L, 37L); $\mathrm{V}+=7.5 \mathrm{~V}$ to 13.2 V (ADM231L \& ADM239L); C1-C4 $=1.0 \mu \mathrm{~F}$ Ceramic. All Specifications $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ unless otherwise noted.)


NOTE
${ }^{1}$ Sample tested to ensure compliance.
Specifications subject to change without notice.
ABSOLUTE MAXIMUM RATINGS*
( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise noted)

| $\mathrm{V}_{\text {cc }}$ | -0.3 V to +6 V |
| :---: | :---: |
| V+ | $\left(\mathrm{V}_{\mathrm{cc}}-0.3 \mathrm{~V}\right)$ to +14 V |
| V- | . . . +0.3 V to -14 V |
| Input Voltages |  |
| $\mathrm{T}_{\text {IN }}$ | -0.3 V to $\left(\mathrm{V}_{\mathrm{Cc}}+0.3 \mathrm{~V}\right)$ |
| $\mathrm{R}_{\text {IN }}$ | $\ldots{ }^{\text {. . }} \pm 30 \mathrm{~V}$ |

Output Voltages
$\mathrm{T}_{\text {Out }} \ldots \ldots . . . . . . . .(\mathrm{V}+,+0.3 \mathrm{~V})$ to $(\mathrm{V}-,-0.3 \mathrm{~V})$

Short Circuit Duration
Tout
Continuous
Power Dissipation
$\mathrm{N}-14$ DIP (Derate $10 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) . . . . . 800 mW
N-16 DIP (Derate $10.5 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) . . . . 840 mW
N-20 DIP (Derate $11 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) . . . . . 890 mW
N -24 DIP (Derate $13.5 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) . . . 1000 mW
N-24A DIP (Derate $13.5 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) . . 500 mW
R-16 SOIC (Derate $9 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) . . . . . 760 mW
R-20 SOIC (Derate $9.5 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) . . . 800 mW
R-24 SOIC (Derate $12 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) $\ldots . . .850 \mathrm{~mW}$
R-28 SOIC (Derate $12.5 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) . . . 900 mW
RS-28 SSOP (Derate $10 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) $\ldots 900 \mathrm{~mW}$
Q-14 Cerdip (Derate $10 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) . . . 720 mW
Q-16 Cerdip (Derate $10 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) $\ldots 800 \mathrm{~mW}$
Q-20 Cerdip (Derate $11.2 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) . . 890 mW
Q-24 Cerdip (Derate $12.5 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) . . 1000 mW
D-24 Ceramic (Derate $20 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) . . 1000 mW
Thermal Impedance, $\boldsymbol{\theta}_{\mathrm{JA}}$
N-14 DIP ..... $140^{\circ} \mathrm{C} / \mathrm{W}$
N-16 DIP ..... $135^{\circ} \mathrm{C} / \mathrm{W}$
N-20 DIP ..... $125^{\circ} \mathrm{C} / \mathrm{W}$
$\mathrm{N}-24$ DIP ..... $120^{\circ} \mathrm{C} / \mathrm{W}$
N-24A DIP ..... $110^{\circ} \mathrm{C} / \mathrm{W}$
R-16 SOIC ..... $105^{\circ} \mathrm{C} / \mathrm{W}$
R-20 SOIC ..... $105^{\circ} \mathrm{C} / \mathrm{W}$
R-24 SOIC ..... $85^{\circ} \mathrm{C} / \mathrm{W}$
R-28 SOIC ..... $80^{\circ} \mathrm{C} / \mathrm{W}$
RS-28 SSOP ..... $100^{\circ} \mathrm{C} / \mathrm{W}$
Q-14 Cerdip ..... $105^{\circ} \mathrm{C} / \mathrm{W}$
Q-16 Cerdip ..... $100^{\circ} \mathrm{C} / \mathrm{W}$
Q-20 Cerdip ..... $100^{\circ} \mathrm{C} / \mathrm{W}$
Q-24 Cerdip ..... $55^{\circ} \mathrm{C} / \mathrm{W}$
D-24 Ceramic ..... $50^{\circ} \mathrm{C} / \mathrm{W}$
Operating Temperature Range
Commercial (J Version) ..... 0 to $+70^{\circ} \mathrm{C}$
Industrial (A Version) ..... $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range ..... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature, Soldering ..... $+300^{\circ} \mathrm{C}$
Vapour Phase ( 60 sec ) ..... $+215^{\circ} \mathrm{C}$
Infrared (15 sec) ..... $+220^{\circ} \mathrm{C}$
ESD Rating ..... $>2000 \mathrm{~V}$
*This is a stress rating only and functional operation of the device at these orany other conditions above those indicated in the operation sections of thisspecification is not implied. Exposure to absolute maximum rating conditionsfor extended periods of time may affect reliability.

ORDERING GUIDE

| Model | Temperature Range | Package Option ${ }^{\star}$ | Model | Temperature Range | Package Option ${ }^{\star}$ | Model | Temperature Range | Package Option ${ }^{*}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ADM223 |  |  | ADM230L |  |  | ADM231L |  |  |
| ADM223AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | R-28 | ADM230LJN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | N-20 | ADM231LJN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | N-14 |
| ADM223ARS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | RS-28 | ADM230LJR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | R-20 | ADM231LJR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | R-16 |
|  |  |  | ADM230LAN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | N-20 | ADM231LAN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | N-14 |
|  |  |  | ADM230LAR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | R-20 | ADM231LAR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | R-16 |
|  |  |  | ADM230LAQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Q-20 | ADM231LAQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Q-14 |
| ADM232L |  |  | ADM233L |  |  | ADM234L |  |  |
| ADM232LJN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | N-16 | ADM233LJN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | N-20 | ADM234LJN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | N-16 |
| ADM232LJR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | R-16 | ADM233LAN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | N-20 | ADM234LJR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | R-16 |
| ADM232LAN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | N-16 |  |  |  | ADM234LAN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | N-16 |
| ADM232LAR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | R-16 |  |  |  | ADM234LAR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | R-16 |
| ADM232LAQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Q-16 |  |  |  | ADM234LAQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Q-16 |
| ADM235L |  |  | ADM236L |  |  | ADM237L |  |  |
| ADM235LJN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | N-24A | ADM236LJN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | N-24 | ADM237LJN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | N-24 |
| ADM235LAN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | N-24A | ADM236LJR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | R-24 | ADM237LJR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | R-24 |
| ADM235LAQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | D-24 | ADM236LAN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | N-24 | ADM237LAN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | N-24 |
|  |  |  | ADM236LAR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | R-24 | ADM237LAR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | R-24 |
|  |  |  | ADM236LAQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Q-24 | ADM237LAQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Q-24 |
| ADM238L |  |  | ADM239L |  |  | ADM241L |  |  |
| ADM238LJN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | N-24 | ADM239LJN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | N-24 | ADM241LJR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | R-28 |
| ADM238LJR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | R-24 | ADM239LJR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | R-24 | ADM241LAR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | R-28 |
| ADM238LAN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | N-24 | ADM239LAN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | N-24 | ADM241LJRS | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | RS-28 |
| ADM238LAR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | R-24 | ADM239LAR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | R-24 | ADM241LARS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | RS-28 |
| ADM238LAQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Q-24 | ADM239LAQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Q-24 |  |  |  |

$\star$ D $=$ Ceramic DIP; N = Plastic DIP; $\mathrm{Q}=$ Cerdip; $\mathrm{R}=$ Small Outline IC (SOIC); RS = Small Shrink Outline Package (SSOP).


Figure 1. ADM230L DIP/SOIC Pin Configuration

*INTERNAL 400K\& PULL-UP RESISTOR ON EACH TTLCMOS INPUT
Figure 2. ADM230L Typical Operating Circuit


Figure 3. ADM231L DIP \& SOIC Pin Configurations

*INTERNAL 400Kת PULL-UP RESISTOR ON EACH TTUCMOS INPUT *INTERNAL $5 K \Omega$ PULL-DOWN RESISTOR ON EACH RS-232 INPUT

Figure 4. ADM231L Typical Operating Circuit (DIP Pinout)


Figure 5. ADM232L DIP/SOIC Pin Configuration

*INTERNAL 400k $\Omega$ PULL-UP RESISTOR ON EACH TTL/CMOS INPUT **NTERNAL 5k $\Omega$ PULL-DOWN RESISTOR ON EACH RS-232 INPUT

Figure 6. ADM232L Typical Operating Circuit


Figure 7. ADM233L DIP Pin Configuration

*INTERNAL 400k $\Omega$ PULL-UP RESISTOR ON EACH TTL/CMOS INPUT **NTERNAL 5k $\Omega$ PULLL-DOWN RESISTOR ON EACH RS-232 INPUT

Figure 8. ADM233L Typical Operating Circuit


Figure 9. ADM234L DIP/SOIC Pin Configuration

*INTERNAL 400KR PULL-UP RESISTOR ON EACH TTLCMOS INPUT
Figure 10. ADM234L Typical Operating Circuit

Figure 11. ADM235L DIP Pin Configuration


Figure 12. ADM235L Typical Operating Circuit


Figure 13. ADM236L DIP/SOIC Pin Configuration

*INTERNAL 400k $\Omega$ PULL-UP RESISTOR ON EACH TTL/CMOS INPUT **INTERNAL 5k 2 PULL-DOWN RESISTOR ON EACH RS-232 INPUT

Figure 14. ADM236L Typical Operating Circuit


Figure 15. ADM237L DIP/SOIC Pin Configuration

*INTERNAL 400k $\Omega$ PULL-UP RESISTOR ON EACH TTL/CMOS INPUT **NTERNAL 5k 2 PULL-DOWN RESISTOR ON EACH RS-232 INPUT

Figure 16. ADM237L Typical Operating Circuit


Figure 17. ADM238L DIP/SOIC Pin Configuration


Figure 18. ADM238L Typical Operating Circuit


Figure 19. ADM239L DIP/SOIC Pin Configuration

*INTERNAL 400ks PULL-UP RESISTOR ON EACH TTL/CMOS INPUT **NTERNAL 5k 2 PULL-DOWN RESISTOR ON EACH RS-232 INPUT
Figure 20. ADM239L Typical Operating Circuit


Figure 21. ADM241L SOIC/SSOP Pin Configuration


Figure 23. ADM223 SOIC/SSOP Pin Configuration

*INTERNAL 400k 2 PULL-UP RESISTOR ON EACH TTL/CMOS INPUT **NTERNAL 5k 2 PULL-DOWN RESISTOR ON EACH RS-232 INPUT Figure 22. ADM241L Typical Operating Circuit

*INTERNAL 400k $\Omega$ PULL-UP RESISTOR ON EACH TTL/CMOS INPUT **INTERNAL 5k $\Omega$ PULL-DOWN RESISTOR ON EACH RS-232 INPUT NOTE: RECEIVERS R4 AND R5 REMAIN ACTIVE IN SHUTDOWN.
Figure 24. ADM223 Typical Operating Circuit

| Mnemonic | Function |
| :---: | :---: |
| $\mathrm{V}_{\mathrm{Cc}}$ | Power Supply Input $5 \mathrm{~V} \pm 10 \%$ ( $+5 \mathrm{~V} \pm 5 \%$ ADM233L, ADM235L). |
| V+ | Internally generated positive supply ( +10 V nominal) on all parts except ADM231L and ADM239L. ADM231L, ADM239L requires external 7.5 V to 13.2 V supply. |
| V- | Internally generated negative supply ( -10 V nominal). |
| GND | Ground pin. Must be connected to 0 V . |
| C+ | (ADM231L and ADM239L only). External capacitor (+ terminal) is connected to this pin. |
| C- | (ADM231L and ADM239L only). External capacitor (- terminal) is connected to this pin. |
| $\mathrm{Cl}+$ | (ADM230L, ADM232L, ADM234L, ADM236L, ADM237L, ADM238L, ADM241L) External capacitor (+ terminal) is connected to this pin. <br> (ADM233L) The capacitor is connected internally and no external connection to this pin is required. |
| C1- | (ADM230L, ADM232L, ADM234L, ADM236L, ADM237L, ADM238L, ADM241L) External capacitor (- terminal) is connected to this pin. <br> (ADM233L) The capacitor is connected internally and no external connection to this pin is required. |
| C2+ | (ADM230L, ADM232L, ADM234L, ADM236L, ADM237L, ADM238L, ADM241L) External capacitor (+ terminal) is connected to this pin. <br> (ADM233L) Internal capacitor connections, Pins 11 and 15 must be connected together. |
| C2- | (ADM230L, ADM232L, ADM234L, ADM236L, ADM237L, ADM238L, ADM241L) External capacitor (- terminal) is connected to this pin. <br> (ADM233L) Internal capacitor connections, Pins 10 and 16 must be connected together. |
| $\mathrm{T}_{\text {IN }}$ | Transmitter (Driver) Inputs. These inputs accept TTL/CMOS levels. An internal $400 \mathrm{k} \Omega$ pull-up resistor to $\mathrm{V}_{\mathrm{CC}}$ is connected on each input. |
| $\mathrm{T}_{\text {OUT }}$ | Transmitter (Driver) Outputs. These are RS-232 levels (typically $\pm 10 \mathrm{~V}$ ). |
| $\mathrm{R}_{\mathrm{IN}}$ | Receiver Inputs. These inputs accept RS-232 signal levels. An internal $5 \mathrm{k} \Omega$ pull-down resistor to GND is connected on each input. |
| $\mathrm{R}_{\text {OUT }}$ | Receiver Outputs. These are TTL/CMOS levels. |
| $\overline{\mathrm{EN}} / \mathrm{EN}$ | Enable Input. Active low on ADM235L, ADM236L, ADM239L, ADM241L. Active high ADM223. This input is used to enable/disable the receiver outputs. With $\overline{\mathrm{EN}}=$ low ( $\mathrm{EN}=$ high ADM 223 ), the receiver outputs are enabled. With $\overline{\mathrm{EN}}=$ high (EN = low ADM223), the outputs are placed in a high impedance state. This facility is useful for connecting to microprocessor systems. |
| SD/ $\overline{S D}$ | Shutdown Input. Active high on ADM235L, ADM236L, ADM241L. Active low on ADM223. With SD = high on the ADM235L, ADM236L, ADM241L, the charge pump is disabled, the receiver outputs are placed in a high impedance state and the driver outputs are turned off. With $\overline{S D}$ low on the ADM223, the charge pump is disabled, the driver outputs are turned off and all receivers except R4 and R5 are placed in a high impedance state. In shutdown, the power consumption reduces to $5 \mu \mathrm{~W}$. |
| NC | No Connect. No connections are required to this pin. |

Table I. ADM235L, ADM236L, ADM241L Truth Table

| SD | $\overline{\text { EN }}$ | Status | Transmitters <br> T1-T5 | Receivers <br> R1-R5. |
| :--- | :--- | :--- | :--- | :--- |
| 0 | 0 | Normal Operation | Enabled | Enabled |
| 0 | 1 | Normal Operation | Enabled | Disabled |
| 1 | 0 | Shutdown | Disabled | Disabled |

Table II. ADM223 Truth Table

|  |  |  | Transmitters | Receivers |  |
| :--- | :--- | :--- | :--- | :--- | :--- |
| $\overline{\text { SD }}$ | EN | Status | T1-T4 | R1-R3 | R4, R5 |
| 0 | 0 | Shutdown | Disabled | Disabled | Disabled |
| 0 | 1 | Shutdown | Disabled | Disabled | Enabled |
| 1 | 0 | Normal Operation | Enabled | Disabled | Disabled |
| 1 | 1 | Normal Operation | Enabled | Enabled | Enabled |

## FEATURES

Meets EIA RS-485 Standard
$5 \mathrm{Mb} / \mathrm{s}$ Data Rate
Single +5 V Supply
-7 V to +12 V Bus Common-Mode Range
High Speed, Low Power BiCMOS
Thermal Shutdown Protection
Short Circuit Protection
Zero Skew Driver
Driver Propagation Delay: 10 ns
Receiver Propagation Delay: 25 ns
High $Z$ Outputs with Power Off
Superior Upgrade for LTC485

## APPLICATIONS

Low Power RS-485 Systems
DTE-DCE Interface
Packet Switching
Local Area Networks
Data Concentration
Data Multiplexers
Integrated Services Digital Network (ISDN)

## DESCRIPTION

The ADM485 is a differential line transceiver suitable for high speed bidirectional data communication on multipoint bus transmission lines. It is designed for balanced data transmission and complies with both EIA Standards RS-485 and RS-422. The part contains a differential line driver and a differential line receiver. Both the driver and the receiver may be enabled independently. When disabled, the outputs are tristated.
The ADM485 operates from a single +5 V power supply. Excessive power dissipation caused by bus contention or by output shorting is prevented by a thermal shutdown circuit. This feature forces the driver output into a high impedance state if during fault conditions a significant temperature increase is detected in the internal driver circuitry.
Up to 32 transceivers may be connected simultaneously on a bus, but only one driver should be enabled at any time. It is important therefore that the remaining disabled drivers do not load the bus. To ensure this, the ADM485 driver features high output impedance when disabled and also when powered down.

FUNCTIONAL BLOCK DIAGRAM


This minimizes the loading effect when the transceiver is not being utilized. The high impedance driver output is maintained over the entire common-mode voltage range from -7 V to +12 V .

The receiver contains a fail safe feature which results in a logic high output state if the inputs are unconnected (floating).
The ADM485 is fabricated on BiCMOS, an advanced mixed technology process combining low power CMOS with fast switching bipolar technology. All inputs and outputs contain protection against ESD; all driver outputs feature high source and sink current capability. An epitaxial layer is used to guard against latch-up.
The ADM485 features extremely fast switching speeds. Minimal driver propagation delays permit transmission at data rates up to $5 \mathrm{Mbits} / \mathrm{s}$ while low skew minimizes EMI interference.

The part is fully specified over the commercial and industrial temperature range and is available in an 8-pin DIL/ SOIC package.

## ADMA85 ـSPEG|F|GATMNS $\left(V_{C C}=+5 \mathrm{~V} \pm 5 \%\right.$. All specifications $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {max }}$ unless otherwise noted. $)$

| Parameter | Min | Typ | Max | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DRIVER <br> Differential Output Voltage, $\mathrm{V}_{\mathrm{OD}}$ |  |  |  |  |  |
|  |  |  | 5.0 | V | $\mathbf{R}=\infty$, Figure 1 |
|  | 2.0 |  | 5.0 | V | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{R}=50 \Omega$ (RS422), Figure 1 |
|  | 1.5 |  | 5.0 | V | $\mathrm{R}=27 \Omega$ (RS485), Figure 1 |
| $\mathrm{V}_{\mathrm{OD} 3}$ | 1.5 |  | 5.0 | V | $\mathrm{V}_{\mathrm{TST}}=-7 \mathrm{~V}$ to +12 V , Figure 2 |
| $\Delta\left\|\mathbf{V}_{\text {OD }}\right\|$ for Complementary Output States |  |  | 0.2 | V | $\mathrm{R}=27 \Omega$ or $50 \Omega$, Figure 1 |
| Common-Mode Output Voltage $\mathrm{V}_{\text {OC }}$ |  |  | 3 | V | $\mathrm{R}=27 \Omega$ or $50 \Omega$, Figure 1 |
| $\Delta\left\|\mathrm{V}_{\text {oc }}\right\|$ for Complementary Output States |  |  | 0.2 | V | $\mathrm{R}=27 \Omega$ or $50 \Omega$ |
| Output Short Circuit Current ( $\mathrm{V}_{\text {OUT }}=$ High $)$ | 35 |  | 250 | mA | $-7 \mathrm{~V} \leq \mathrm{V}_{\mathrm{O}} \leq+12 \mathrm{~V}$ |
| Output Short Circuit Current ( $\mathrm{V}_{\text {Out }}=$ Low $)$ | 35 |  | 250 | mA | $-7 \mathrm{~V} \leq \mathrm{V}_{\mathrm{O}} \leq+12 \mathrm{~V}$ |
| CMOS Input Logic Threshold Low, $\mathrm{V}_{\text {INL }}$ |  |  | 0.8 | V |  |
| CMOS Input Logic Threshold High, $\mathrm{V}_{\text {INH }}$ | 2.0 |  |  | V |  |
| Logic Input Current (DE, DI) |  |  | $\pm 1.0$ | $\mu \mathrm{A}$ |  |
| RECEIVER |  |  |  |  |  |
| Differential Input Threshold Voltage, $\mathrm{V}_{\text {TH }}$ | -0.2 |  | +0.2 | V | $-7 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CM}} \leq+12 \mathrm{~V}$ |
| Input Voltage Hysteresis, $\Delta \mathbf{V}_{\text {TH }}$ |  | 70 |  | mV | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ |
| Input Resistance | 12 |  |  | $\mathrm{k} \Omega$ | $-7 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CM}} \leq+12 \mathrm{~V}$ |
| Input Current (A, B) |  |  | +1 | mA | $\mathrm{V}_{\text {IN }}=12 \mathrm{~V}$ |
|  |  |  | -0.8 | mA | $\mathrm{V}_{\mathrm{IN}}=-7 \mathrm{~V}$ |
| Logic Enable Input Current ( $\overline{\mathrm{RE}})$ |  |  | $\pm 1$ | $\mu \mathrm{A}$ |  |
| CMOS Output Voltage Low, $\mathrm{V}_{\mathrm{OL}}$ |  |  | 0.4 | V | $\mathrm{I}_{\text {OUT }}=+4.0 \mathrm{~mA}$ |
| CMOS Output Voltage High, $\mathrm{V}_{\mathrm{OH}}$ | 4.0 |  |  | V | $\mathrm{I}_{\text {OUT }}=-4.0 \mathrm{~mA}$ |
| Short Circuit Output Current | 7 |  | 85 | mA | $\mathrm{V}_{\text {OUT }}=\mathrm{GND}$ or $\mathrm{V}_{\text {CC }}$ |
| Tristate Output Leakage Current |  |  | $\pm 1.0$ | $\mu \mathrm{A}$ | $0.4 \mathrm{~V} \leq \mathrm{V}_{\text {OUT }} \leq+2.4 \mathrm{~V}$ |
| POWER SUPPLY CURRENT |  |  |  |  |  |
| $\mathrm{I}_{\mathrm{CC}}$ (Outputs Enabled) |  | 1.35 | 2.2 | mA | Outputs Unloaded, Digital Inputs $=\mathrm{GND}$ or $\mathrm{V}_{\mathrm{CC}}$ |
| $\mathrm{I}_{\mathrm{CC}}$ (Outputs Disabled) |  | 0.7 | 1 | mA | Outputs Unloaded, Digital Inputs $=$ GND or $\mathrm{V}_{\mathrm{CC}}$ |

Specifications subject to change without notice.

## TIMING SPECIFICATIONS $\left(V_{c c}=+5 \mathrm{~V} \pm 5 \%\right.$. All specifications $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {Max }}$ unless otherwise noted.)

| Parameter | Min | Typ | Max | Units | Test Conditions/ Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DRIVER <br> Propagation Delay Input to Output $\mathrm{T}_{\mathrm{PLH}}, \mathrm{T}_{\mathrm{PHL}}$ <br> Driver O/P to $\overline{\mathrm{O} / \mathrm{P}} \mathrm{T}_{\text {SKEW }}$ <br> Driver Rise/Fall Time $\mathrm{T}_{\mathrm{R}}, \mathrm{T}_{\mathrm{F}}$ <br> Driver Enable to Output Valid <br> Driver Disable Timing | 2 | $\begin{aligned} & 10 \\ & 0 \\ & 2 \\ & 10 \\ & 10 \end{aligned}$ | $\begin{aligned} & 15 \\ & 5 \\ & 10 \\ & 25 \\ & 25 \end{aligned}$ | $\begin{aligned} & \text { ns } \\ & \text { ns } \\ & \text { ns } \\ & \text { ns } \\ & \text { ns } \end{aligned}$ | $\begin{aligned} & R_{\mathrm{L}} \text { Diff }=54 \Omega \mathrm{C}_{\mathrm{L} 1}=\mathrm{C}_{\mathrm{L} 2}=100 \mathrm{pF}, \text { Figure } 3 \\ & \mathrm{R}_{\mathrm{L}} \text { Diff }=54 \Omega \mathrm{C}_{\mathrm{L} 1}=\mathrm{C}_{\mathrm{L} 2}=100 \mathrm{pF}, \text { Figure 3 } \\ & \mathrm{R}_{\mathrm{L}} \text { Diff }=54 \Omega \mathrm{C}_{\mathrm{L} 1}=\mathrm{C}_{\mathrm{L} 2}=100 \mathrm{pF}, \text { Figure } 3 \end{aligned}$ |
| RECEIVER <br> Propagation Delay Input to Output $\mathrm{T}_{\mathrm{PLH}}, \mathrm{T}_{\mathrm{PHL}}$ <br> Skew $\left\|\mathrm{T}_{\mathrm{PLH}}-\mathrm{T}_{\mathrm{PHL}}\right\|$ <br> Receiver Enable $\mathrm{T}_{\mathrm{EN} 1}$ <br> Receiver Disable TEN2 | 18 | $\begin{aligned} & 25 \\ & 0 \\ & 15 \\ & 15 \end{aligned}$ | $\begin{aligned} & 40 \\ & 5 \\ & 25 \\ & 25 \end{aligned}$ | ns <br> ns <br> ns <br> ns | $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF} \text {, Figure } 5$ <br> Figure 6 <br> Figure 6 |

Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS*

( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise noted)
$\mathrm{v}_{\mathrm{cc}}$............................................. . . . +7 V

## Inputs

Outputs

$$
\text { Driver Outputs . . . . . . . . . . . . . . . . }-14 \mathrm{~V} \text { to }+14 \mathrm{~V}
$$

$$
\text { Receiver Output . . . . . . . . . . . . . }-0.5 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{CC}}+0.5 \mathrm{~V}
$$

$$
\text { Power Dissipation 8-Pin DIP . . . . . . . . . . . . . . . . . } 500 \mathrm{~mW}
$$

$$
\theta_{\mathrm{JA}} \text {, Thermal Impedance . . . . . . . . . . . . . . . }+130^{\circ} \mathrm{C} / \mathrm{W}
$$

$$
\text { Power Dissipation 8-Pin SOIC . . . . . . . . . . . . . . . } 450 \mathrm{~mW}
$$

$$
\theta_{\mathrm{JA}} \text {, Thermal Impedance } . \cdots \text {. . . . . . . . . . . . }+170^{\circ} \mathrm{C} / \mathrm{W}
$$

$$
\text { Power Dissipation 8-Pin Cerdip . . . . . . . . . . . . . . } 500 \mathrm{~mW}
$$

$$
\theta_{\mathrm{JA}} \text {, Thermal Impedance . . . . . . . . . . . . . . . }+125^{\circ} \mathrm{C} / \mathrm{W}
$$

Operating Temperature Range

$$
\text { Commercial (J Version) . . . . . . . . . . . . . . . } 0^{\circ} \mathrm{C} \text { to }+70^{\circ} \mathrm{C}
$$

$$
\text { Industrial (A Version) . . . . . . . . . . . . . . . }-40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C}
$$

$$
\text { Storage Temperature Range . . . . . . . . . . }-65^{\circ} \mathrm{C} \text { to }+150^{\circ} \mathrm{C}
$$

$$
\text { Lead Temperature (Soldering, } 10 \mathrm{sec} \text { ) . . . . . . . . . . }+300^{\circ} \mathrm{C}
$$

$$
\text { Vapour Phase ( } 60 \mathrm{sec} \text { ) . . . . . . . . . . . . . . . . . . . . }+215^{\circ} \mathrm{C}
$$

$$
\text { Infrared (15 sec) . . . . . . . . . . . . . . . . . . . . . . . . + } 220^{\circ} \mathrm{C}
$$

*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum ratings for extended periods of time may affect device reliability.

Table I. Transmitting

|  | INPUTS |  | OUTPUTS |  |
| :--- | :--- | :--- | :--- | :--- |
| $\overline{\mathbf{R E}}$ | $\mathbf{D E}$ | $\mathbf{D I}$ | $\mathbf{B}$ | $\mathbf{A}$ |
| $\mathbf{X}$ | 1 | 1 | 0 | 1 |
| $\mathbf{X}$ | 1 | 0 | 1 | 0 |
| $\mathbf{X}$ | 0 | $\mathbf{X}$ | $\mathbf{Z}$ | $\mathbf{Z}$ |

Table II. Receiving

| INPUTS |  |  | OUTPUT |
| :--- | :--- | :--- | :--- |
| $\overline{\mathbf{R E}}$ | DE | A-B | RO |
| 0 | 0 | $\geq+0.2 \mathrm{~V}$ | 1 |
| 0 | 0 | $\leq-0.2 \mathrm{~V}$ | 0 |
| 0 | 0 | Inputs Open | 1 |
| 1 | 0 | X | Z |

$$
\begin{aligned}
& \text { Driver Input (DI) . . . . . . . . . . . }-0.3 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{CC}}+0.3 \mathrm{~V} \\
& \text { Control Inputs (DE, RE) . . . . . . . }-0.3 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{cc}}+0.3 \mathrm{~V} \\
& \text { Receiver Inputs (A, B) . . . . . . . . . . . . . . }-14 \mathrm{~V} \text { to }+14 \mathrm{~V}
\end{aligned}
$$

PIN FUNCTION DESCRIPTION

| Pin | Mnemonic | Function |
| :--- | :--- | :--- |
| 1 | RO | Receiver Output. When enabled if A $>$ B by <br> 200 mV, then RO = High. If A $<\mathrm{B}$ by <br> 200 mV , then RO = Low. <br> Receiver Output Enable. A low level enables <br> the receiver output, RO. A high level places <br> it in a high impedance state. <br> Driver Output Enable. A high level enables <br> the driver differential outputs, A and B. A <br> low level places it in a high impedance state. <br> Driver Input. When the driver is enabled a <br> logic Low on DI forces A low and B high <br> while a logic High on DI forces A high and B <br> low. |
| 4 | DE | DI |
| 5 | GND | Ground Connection, 0 V. <br> 6 |
| 7 | B | Noninverting Receiver Input A/Driver <br> Output A. <br> Inverting Receiver Input B/Driver Output B. |
| 8 | $V_{\text {CC }}$ | Power Supply, 5 V $\pm 5 \%$. |

## PIN CONFIGURATION



ORDERING GUIDE

| Model | Temperature Range | Package Option ${ }^{\star}$ |
| :--- | :--- | :--- |
| ADM485JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| ADM485JR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{R}-8$ |
| ADM485AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| ADM485AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-8$ |
| ADM485AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |

*For outline information see Package Information section.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the ADM485 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


## Test Circuits



Figure 1. Driver Voltage Measurement Test Circuit


Figure 2. Driver Voltage Measurement Test Circuit 2


Figure 3. Driver Propagation Delay Test Circuit


Figure 4. Driver Enable/Disable Test Circuit


Figure 5. Receiver Propagation Delay Test Circuit


Figure 6. Receiver Enable/Disable Test Circuit

## Switching Characteristics



Figure 7. Driver Propagation Delay, Rise/Fall Timing


Figure 8. Driver Enable/Disable Timing


Figure 9. Receiver Propagation Delay


Figure 10. Receiver Enable/Disable Timing


Figure 11. Receiver Output Low Voltage vs. Output Current


Figure 14. Receiver Output Low Voltage vs. Temperature


Figure 17. Driver Output Low Voltage vs. Output Current


Figure 12. Receiver Output High Voltage vs. Output Current


Figure 15. Driver Differential Output Voltage vs. Output Current


Figure 18. Driver Output High Voltage vs. Output Current


Figure 13. Receiver Output High Voltage vs. Temperature


Figure 16. Driver Differential Output Voltage vs. Temperature, $R_{L}=54 \Omega$


Figure 19. Supply Current vs. Temperature

## ADM485-Typical Performance Characteristics



Figure 20. Receiver $t_{P L H}-t_{P H L}$ vs. Temperature


Figure 23. Loaded Driver Differential Outputs


Figure 21. Driver Skew vs. Temperature


Figure 24. Driver/Receiver Propagation Delays Low to High


Figure 22. Unloaded Driver Differential Outputs


Figure 25. Driver/Receiver Propagation Delays High to Low


Figure 26. Typical RS-485 Network

## APPLICATIONS INFORMATION

## Differential Data Transmission

Differential data transmission is used to reliably transmit data at high rates over long distances and through noisy environments. Differential transmission nullifies the effects of ground shifts and noise signals which appear as common-mode voltages on the line. There are two main standards approved by the Electronics Industries Association (EIA) which specify the electrical characteristics of transceivers used in differential data transmission.

The RS-422 standard specifies data rates up to 10 MBaud and line lengths up to 4000 ft . A single driver can drive a transmission line with up to 10 receivers.
In order to cater for true multipoint communications, the RS-485 standard was defined. This standard meets or exceeds all the requirements of RS-422 but also allows for up to 32 drivers and 32 receivers to be connected to a single bus. An extended common-mode range of -7 V to +12 V is defined. The most significant difference between RS-422 and RS-485 is the fact that the drivers may be disabled thereby allowing more than one ( 32 in fact) to be connected to a single line. Only one driver should be enabled at time, but the RS- 485 standard contains additional specifications to guarantee device safety in the event of line contention.

## Cable and Data Rate

The transmission line of choice for RS-485 communications is a twisted pair. Twisted pair cable tends to cancel common-mode noise and also causes cancellation of the magnetic fields generated by the current flowing through each wire, thereby, reducing the effective inductance of the pair.
The ADM485 is designed for bidirectional data communications on multipoint transmission lines. A typical application showing a
multipoint transmission network is illustrated in Figure 26. An RS-485 transmission line can have as many as 32 transceivers on the bus. Only one driver can transmit at a particular time but multiple receivers may be enabled simultaneously.
As with any transmission line, it is important that reflections are minimized. This may be achieved by terminating the extreme ends of the line using resistors equal to the characteristic impedance of the line. Stub lengths of the main line should also be kept as short as possible. A properly terminated transmission line appears purely resistive to the driver.

## Thermal Shutdown

The ADM485 contains thermal shutdown circuitry which protects the part from excessive power dissipation during fault conditions. Shorting the driver outputs to a low impedance source can result in high driver currents. The thermal sensing circuitry detects the increase in die temperature and disables the driver outputs. The thermal sensing circuitry is designed to disable the driver outputs when a die temperature of $150^{\circ} \mathrm{C}$ is reached. As the device cools, the drivers are re-enabled at $140^{\circ} \mathrm{C}$.

## Propagation Delay

The ADM485 features very low propagation delay ensuring maximum baud rate operation. The driver is well balanced ensuring distortion free transmission.
Another important specification is a measure of the skew between the complementary outputs. Excessive skew impairs the noise immunity of the system and increases the amount of electromagnetic interference (EMI).

## Receiver Open-Circuit Fail Safe

The receiver input includes a fail-safe feature which guarantees a logic high on the receiver when the inputs are open circuit or floating.

Table III. Comparison of RS-422 and RS-485 Interface Standards

| Specification | RS-422 | RS-485 |
| :--- | :--- | :--- |
| Transmission Type | Differential | Differential |
| Maximum Cable Length | 4000 ft. | 4000 ft. |
| Minimum Driver Output Voltage | $\pm 2 \mathrm{~V}$ | $\pm 1.5 \mathrm{~V}$ |
| Driver Load Impedance | $100 \Omega$ | $54 \Omega$ |
| Receiver Input Resistance | $4 \mathrm{k} \Omega \mathrm{min}$ | $12 \mathrm{k} \Omega \mathrm{min}$ |
| Receiver Input Sensitivity | $\pm 200 \mathrm{mV}$ | $\pm 200 \mathrm{mV}$ |
| Receiver Input Voltage Range | -7 V to +7 V | -7 V to +12 V |
| No of Drivers/Receivers Per Line | $1 / 10$ | $32 / 32$ |

## FEATURES

Superior Upgrade for MAX690-MAX695
Specified Over Temperature
Low Power Consumption ( 5 mW )
Precision Voltage Monitor
Reset Assertion Down to 1 V Vcc
Low Switch On-Resistance $1.5 \Omega$ Normal, $20 \Omega$ in Backup
High Current Drive ( 100 mA )
Watchdog Timer-100 ms, $\mathbf{1 . 6} \mathbf{~ s}$, or Adjustable 600 nA Standby Current
Automatic Battery Backup Power Switching
Extremely Fast Gating of Chip Enable Signals (5 ns) Voltage Monitor for Power Fail
APPLICATIONS
Microprocessor Systems
Computers
Controllers
Intelligent Instruments
Automotive Systems

## GENERAL DESCRIPTION

The ADM690-ADM695 family of supervisory circuits offers complete single chip solutions for power supply monitoring and battery control functions in microprocessor systems. These functions include $\mu \mathrm{P}$ reset, backup battery switchover, watchdog timer, CMOS RAM write protection, and power failure warning. The complete family provides a variety of configurations to satisfy most microprocessor system requirements.
The ADM690, ADM692 and ADM694 are available in 8-pin DIP packages and provide:

1. Power-on reset output during power-up, power-down and brownout conditions. The RESET output remains operational with $\mathrm{V}_{\mathrm{CC}}$ as low as 1 V .
2. Battery backup switching for CMOS RAM, CMOS microprocessor or other low power logic.
3. A reset pulse if the optional watchdog timer has not been toggled within a specified time.
4. A 1.3 V threshold detector for power fail warning, low battery detection, or to monitor a power supply other than +5 V .

The ADM691, ADM693 and ADM695 are available in 16-pin DIP and small outline packages and provide three additional functions:

1. Write protection of CMOS RAM or EEPROM.
2. Adjustable reset and watchdog timeout periods.
3. Separate watchdog timeout, backup battery switchover, and low $\mathrm{V}_{\mathrm{CC}}$ status outputs.

FUNCTIONAL BLOCK DIAGRAMS

${ }^{1}$ VOLTAGE DETECTOR $=4.65 \mathrm{~V}$ (ADM690, ADM694) 4.40 V (ADM692)

2RESET PULSE WIDTH $=50 \mathrm{~ms}$ (ADM690, ADM692)
200ms (ADM694)

${ }^{1}$ VOLTAGE DETECTOR $=4.65 \mathrm{~V}$ (ADM691, ADM695)
4.40V (ADM693)

The ADM690-ADM695 family is fabricated using an advanced epitaxial CMOS process combining low power consumption ( 5 mW ), extremely fast Chip Enable gating ( 5 ns ) and high reliability. $\overline{\text { RESET }}$ assertion is guaranteed with $\mathrm{V}_{\mathrm{CC}}$ as low as 1 V . In addition, the power switching circuitry is designed for minimal voltage drop thereby permitting increased output current drive of up to 100 mA without the need for an external pass transistor.

| Parameter | Min | Typ | Max | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| BATTERY BACKUP SWITCHING <br> $\mathrm{V}_{\mathrm{CC}}$ Operating Voltage Range <br> ADM690, ADM691, ADM694, ADM695 <br> ADM692, ADM693 <br> $\mathrm{V}_{\mathrm{BATt}}$ Operating Voltage Range <br> ADM690, ADM691, ADM694, ADM695 <br> ADM692, ADM693 <br> $\mathrm{V}_{\text {OUT }}$ Output Voltage <br> $\mathrm{V}_{\text {Out }}$ in Battery Backup Mode <br> Supply Current (Excludes $\mathrm{I}_{\text {Out }}$ ) <br> Supply Current in Battery Backup Mode <br> Battery Standby Current <br> ( $+=$ Discharge, $-=$ Charge) <br> Battery Switchover Threshold <br> $\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{BATT}}$ <br> Battery Switchover Hysteresis <br> BATT ON Output Voltage <br> BATT ON Output Short Circuit Current | $\begin{aligned} & 4.75 \\ & 4.5 \\ & 2.0 \\ & 2.0 \\ & \mathrm{~V}_{\mathrm{CC}}-0.05 \\ & \mathrm{~V}_{\mathrm{CC}}-0.5 \\ & \mathrm{~V}_{\mathrm{BATT}}-0.05 \\ & \\ & -0.1 \\ & -1.0 \\ & \\ & 0.5 \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}-0.025 \\ & \mathrm{~V}_{\mathrm{CC}}-0.25 \\ & \mathrm{~V}_{\mathrm{BATT}}-0.02 \\ & 1 \\ & 0.6 \\ & \\ & 70 \\ & 50 \\ & 20 \\ & \\ & 35 \\ & 1 \end{aligned}$ | $\begin{aligned} & 5.5 \\ & 5.5 \\ & 4.25 \\ & 4.0 \\ & \\ & \\ & 1.95 \\ & 1 \\ & +0.02 \\ & +0.02 \\ & \\ & 0.3 \\ & 25 \end{aligned}$ | V V V V V V V mA $\mu \mathrm{A}$ $\mu \mathrm{A}$ $\mu \mathrm{A}$ mV mV mV V mA $\mu \mathrm{A}$ | $\begin{aligned} & \mathrm{I}_{\text {OUT }}=1 \mathrm{~mA} \\ & \mathrm{I}_{\text {OUT }} \leq 100 \mathrm{~mA} \\ & \mathrm{I}_{\text {OUT }}=250 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{CC}}<\mathrm{V}_{\text {BATT }}-0.2 \mathrm{~V} \\ & \mathrm{I}_{\text {OUT }}=100 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{CC}}=0 \mathrm{~V}, \mathrm{~V}_{\text {BATT }}=2.8 \mathrm{~V} \\ & 5.5 \mathrm{~V}>\mathrm{V}_{\mathrm{CC}}>\mathrm{V}_{\text {BATT }}+0.2 \mathrm{~V} \\ & \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \text { Power Up } \\ & \text { Power Down } \\ & \\ & \mathrm{I}_{\text {SINK }}=3.2 \mathrm{~mA} \\ & \text { BATT ON }=\mathrm{V}_{\text {OUT }}=4.5 \mathrm{~V} \text { Sink Current } \\ & \text { BATT ON }=0 \text { V Source Current } \end{aligned}$ |
| RESET AND WATCHDOG TIMER <br> Reset Voltage Threshold <br> ADM690, ADM691, ADM694, ADM695 <br> ADM692, ADM693 <br> Reset Threshold Hysteresis <br> Reset Timeout Delay <br> ADM690, ADM691, ADM692, ADM693 <br> ADM694, ADM695 <br> Watchdog Timeout Period, Internal Oscillator <br> Watchdog Timeout Period, External Clock <br> Minimum WDI Input Pulse Width <br> RESET Output Voltage @ $\mathrm{V}_{\mathrm{CC}}=+1 \mathrm{~V}$ <br> RESET, LOW LINE Output Voltage <br> RESET, $\overline{\text { WDO }}$ Output Voltage <br> Output Short Circuit Source Current <br> Output Short Circuit Sink Current <br> WDI Input Threshold <br> Logic Low <br> Logic High <br> WDI Input Current | 4.5 4.25 35 140 1.0 70 3840 768 50 3.5 3.5 1 3.5 -50 | 4.65 <br> 4.4 <br> 40 <br> 50 <br> 200 <br> 1.6 <br> 100 <br> 4 <br> 3 <br> 25 <br> 20 <br> $-15$ | 4.73 4.48 70 280 2.25 140 4097 1025 200 0.4 0.4 25 0.8 50 | V <br> V <br> mV <br> ms <br> ms <br> s <br> ms <br> Cycles <br> Cycles <br> ns <br> mV <br> V <br> V <br> V <br> V <br> $\mu \mathrm{A}$ <br> mA <br> V <br> V <br> $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ | $\begin{aligned} & \text { OSC SEL }=\mathrm{HIGH}, \mathrm{~V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \text { OSC SEL }=\mathrm{HIGH}, \mathrm{~V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \text { Long Period, } \mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \text { Short Period, } \mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \text { Long Period } \\ & \text { Short Period } \\ & \mathrm{V}_{\mathrm{IL}}=0.4, \mathrm{~V}_{\mathrm{IH}}=3.5 \mathrm{~V} \\ & \mathrm{I}_{\text {IINK }}=10 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{CC}}=1 \mathrm{~V} \\ & \mathrm{I}_{\text {SINK }}=1.6 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CC}}=4.25 \mathrm{~V} \\ & \mathrm{I}_{\text {SOURCE }}=1 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{CC}}=5 \mathrm{~V} \\ & \mathrm{I}_{\text {SINK }}=1.6 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CC}}=5 \mathrm{~V} \\ & \mathrm{I}_{\text {SOURCE }}=1 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{CC}}=4.25 \mathrm{~V} \\ & \\ & \mathrm{~V}_{\mathrm{CC}}=5 \mathrm{~V}^{1} \\ & \\ & \text { WDI }=\mathrm{V}_{\mathrm{OUT}}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \text { WDl }=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \end{aligned}$ |
| POWER FAIL DETECTOR <br> PFI Input Threshold PFI Input Current $\overline{\text { PFO Output Voltage }}$ <br> $\overline{\text { PFO }}$ Short Circuit Source Current $\overline{\text { PFO Short Circuit Sink Current }}$ | $\begin{aligned} & 1.25 \\ & -25 \\ & 3.5 \\ & 1 \end{aligned}$ | $\begin{aligned} & 1.3 \\ & \pm 0.01 \\ & \\ & 3 \\ & 25 \end{aligned}$ | $\begin{aligned} & 1.35 \\ & +25 \\ & 0.4 \\ & \\ & 25 \end{aligned}$ | $\begin{array}{\|l} \hline \mathrm{V} \\ \mathrm{nA} \\ \mathrm{~V} \\ \mathrm{~V} \\ \mu \mathrm{~A} \\ \mathrm{~mA} \end{array}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{SINK}}=3.2 \mathrm{~mA} \\ & \mathrm{I}_{\text {SOURCE }}=1 \mu \mathrm{~A} \\ & \mathrm{PFI}=\text { Low, }, \overline{\mathrm{PFO}}=0 \mathrm{~V} \\ & \mathrm{PFI}=\text { High, } \overline{\mathrm{PFO}}=\mathrm{V}_{\mathrm{OUT}} \end{aligned}$ |
| CHIP ENABLE GATING $\overline{\mathrm{CE}}_{\text {IN }}$ Threshold $\overline{\mathrm{CE}}_{\text {IN }}$ Pull-Up Current $\overline{\mathrm{CE}}_{\text {Out }}$ Output Voltage <br> $\overline{\mathrm{CE}}$ Propagation Delay | $\begin{aligned} & 3.0 \\ & \mathrm{~V}_{\text {OUT }}-1.5 \\ & \mathrm{~V}_{\text {OUT }}-0.05 \end{aligned}$ | $5$ | 0.8 0.4 9 | $\begin{array}{\|l} \mathrm{V} \\ \mathrm{~V} \\ \mu \mathrm{~A} \\ \mathrm{~V} \\ \mathrm{~V} \\ \mathrm{~V} \\ \mathrm{~ns} \end{array}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{IL}} \\ & \mathrm{~V}_{\mathrm{IH}} \\ & \mathrm{I}_{\text {IINK }}=3.2 \mathrm{~mA} \\ & \mathrm{I}_{\text {SOURCE }}=3.0 \mathrm{~mA} \\ & \mathrm{I}_{\text {SOURCE }}=1 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{CC}}=0 \mathrm{~V} \end{aligned}$ |


| Parameter | Min | Typ | Max | Units |
| :--- | :--- | :--- | :--- | :--- | Test Conditions/Comments | OSCILLATOR |
| :--- |
| OSC IN Input Current |

## NOTE

${ }^{1}$ WDI is a three level input which is internally biased to $38 \%$ of $\mathrm{V}_{\mathrm{CC}}$ and has an input impedance of approximately $125 \mathrm{k} \Omega$.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS*

$\left(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right.$ unless otherwise noted)

| $\mathrm{V}_{\mathrm{CC}}$ | -0.3 V to +6 V |
| :---: | :---: |
| $\mathrm{V}_{\text {Batt }}$ | -0.3 V to +6 V |

All Other Inputs . . . . . . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{OUT}}+0.5 \mathrm{~V}$
Input Current
$\mathrm{V}_{\mathrm{CC}}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 200 mA
V Batt . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 50 mA
GND . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 20 mA
Digital Output Current . . . . . . . . . . . . . . . . . . . . . . 20 mA
Power Dissipation, N-8 DIP . . . . . . . . . . . . . . . . . 400 mW
$\theta_{\mathrm{JA}}$ Thermal Impedance . . . . . . . . . . . . . . . . . . $120^{\circ} \mathrm{C} / \mathrm{W}$
Power Dissipation, Q-8 DIP . . . . . . . . . . . . . . . . . 500 mW
$\theta_{\mathrm{JA}}$ Thermal Impedance . . . . . . . . . . . . . . . . . . $125^{\circ} \mathrm{C} / \mathrm{W}$
Power Dissipation, N-16 DIP . . . . . . . . . . . . . . . . 600 mW
$\dot{\theta}_{\text {JA }}$ Thermal Impedance . . . . . . . . . . . . . . . . . . $135^{\circ} \mathrm{C} / \mathrm{W}$
Power Dissipation, Q-16 DIP . . . . . . . . . . . . . . . . 600 mW $\theta_{\mathrm{JA}}$ Thermal Impedance . . . . . . . . . . . . . . . . . . $100^{\circ} \mathrm{C} / \mathrm{W}$
Power Dissipation, R-16 SOIC . . . . . . . . . . . . . . . . 600 mW $\theta_{\mathrm{JA}}$ Thermal Impedance . . . . . . . . . . . . . . . . . . $110^{\circ} \mathrm{C} / \mathrm{W}$
Operating Temperature Range
Industrial (A Version) . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Extended (S Version) . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 secs) . . . . . . . . . . . $+300^{\circ} \mathrm{C}$ Vapor Phase (60 secs) . . . . . . . . . . . . . . . . . . . . $+215^{\circ} \mathrm{C}$ Infrared (15 secs) . . . . . . . . . . . . . . . . . . . . . . . $+220^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum ratings for extended periods of time may affect device reliability.

## ORDERING GUIDE

| Model | Temperature Range | Package Option ${ }^{\text {a }}$ |
| :--- | :--- | :--- |
| ADM690AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| ADM690AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |
| ADM690SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |
| ADM691AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| ADM691AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16$ |
| ADM691AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| ADM691SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| ADM692AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| ADM692AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |
| ADM692SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |
| ADM693AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| ADM693AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16$ |
| ADM693AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| ADM693SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| ADM694AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| ADM694AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |
| ADM694SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |
| ADM695AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| ADM695AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16$ |
| ADM695AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| ADM695SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |

*For outline information see Package Information section.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the ADM690-ADM695 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

## PIN FUNCTION DESCRIPTION

| Mnemonic | Function |
| :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | Power Supply Input: +5 V Nominal. |
| $\mathrm{V}_{\text {batt }}$ | Backup Battery Input. Connect to Ground if a backup battery is not used. |
| $\mathrm{V}_{\text {OUT }}$ | Output Voltage, $\mathrm{V}_{\mathrm{CC}}$ or $\mathrm{V}_{\mathrm{BATT}}$ is internally switched to $\mathrm{V}_{\mathrm{OUT}}$ depending on which is at the highest potential. $\mathrm{V}_{\text {OUT }}$ can supply up to 100 mA to power CMOS RAM. Connect $\mathrm{V}_{\text {OUT }}$ to $\mathrm{V}_{\mathrm{CC}}$ if $\mathrm{V}_{\text {OUT }}$ and $\mathrm{V}_{\text {BATt }}$ are not used. |
| GND | 0 V . Ground reference for all signals. |
| $\overline{\text { RESET }}$ | Logic Output. $\overline{\text { RESET }}$ goes low if <br> 1. $\mathrm{V}_{\mathrm{CC}}$ falls below the Reset Threshold <br> 2. $\mathrm{V}_{\mathrm{CC}}$ falls below $\mathrm{V}_{\mathrm{BATt}}$ <br> 3. The watchdog timer is not serviced within its timeout period. <br> The reset threshold is typically 4.65 V for the ADM690/ADM691/ADM694/ADM695 and 4.4 V for the ADM692 and ADM693. $\overline{\text { RESET }}$ remains low for 50 ms (ADM690/ADM691/ADM692/ADM693) or 200 ms (ADM694/ADM695) after $\mathrm{V}_{\mathrm{CC}}$ returns above the threshold. $\overline{\mathrm{RESET}}$ also goes low for 50 (200) ms if the watchdog timer is enabled but not serviced within its timeout period. The RESET pulse width can be adjusted on the ADM691/ADM693/ADM695 as shown in Table I. The $\overline{\text { RESET }}$ output has an internal $3 \mu \mathrm{~A}$ pull up, and can either connect to an open collector Reset bus or directly drive a CMOS gate without an external pull-up resistor. |
| WDI | Watchdog Input. WDI is a three level input. If WDI remains either high or low for longer than the watchdog timeout period, RESET pulses low and WDO goes low. The timer resets with each transition on the WDI line. The watchdog timer may be disabled if WDI is left floating or is driven to midsupply. |
| PFI | Power Fail Input. PFI is the noninverting input to the Power Fail Comparator When PFI is less than $1.3 \mathrm{~V}, \overline{\mathrm{PFO}}$ goes low. Connect PFI to GND or $\mathrm{V}_{\text {OUt }}$ when not used. |
| $\overline{\mathrm{PFO}}$ | Power Fail Output. $\overline{\mathrm{PFO}}$ is the output of the Power Fail Comparator. It goes low when PFI is less than 1.3 V . The comparator is turned off and $\overline{\mathrm{PFO}}$ goes low when $\mathrm{V}_{\mathrm{CC}}$ is below $\mathrm{V}_{\mathrm{BATt}}$. |
| $\overline{\mathrm{CE}}_{\text {IN }}$ | Logic Input. The input to the $\overline{\mathrm{CE}}$ gating circuit. Connect to GND or $\mathrm{V}_{\text {OUT }}$ if not used. |
| $\overline{\mathrm{CE}}_{\text {OUT }}$ | Logic Output. $\overline{\mathrm{CE}}_{\mathrm{OUT}}$ is a gated version of the $\overline{\mathrm{CE}}_{\text {IN }}$ signal. $\overline{\mathrm{CE}}_{\mathrm{OUT}}$ tracks $\overline{\mathrm{CE}}_{\mathrm{IN}}$ when $\mathrm{V}_{\mathrm{CC}}$ is above the reset threshold. If $\mathrm{V}_{\mathrm{CC}}$ is below the reset threshold, $\overline{\mathrm{CE}}_{\mathrm{OUT}}$ is forced high. See Figures 5 and 6 . |
| BATT ON | Logic Output. BATT ON goes high when $\mathrm{V}_{\text {OUT }}$ is internally switched to the $\mathrm{V}_{\text {BATT }}$ input. It goes low when $\mathrm{V}_{\text {OUT }}$ is internally switched to $\mathrm{V}_{\mathrm{CC}}$. The output typically sinks 35 mA and can directly drive the base of an external PNP transistor to increase the output current above the 100 mA rating of $\mathrm{V}_{\mathrm{OUT}}$. |
| LOW LINE | Logic Output. LOW LINE goes low when $\mathrm{V}_{\mathrm{CC}}$ falls below the reset threshold. It returns high as soon as $\mathrm{V}_{\mathrm{CC}}$ rises above the reset threshold. |
| RESET | Logic Output. RESET is an active high output. It is the inverse of $\overline{\text { RESET }}$ |
| OSC SEL | Logic Oscillator Select Input. When OSC SEL is unconnected (floating) or driven high, the internal oscillator sets the reset active time and watchdog timeout period. When OSC SEL is low, the external oscillator input, OSC IN, is enabled. OSC SEL has a $3 \mu \mathrm{~A}$ internal pull up, (see Table I). |
| OSC IN | Oscillator Logic Input. With OSC SEL low, OSC IN can be driven by an external clock signal or an external capacitor can be connected between OSC IN and GND. This sets both the reset active pulse timing and the watchdog timeout period (see Table I and Figure 4). With OSC SEL high or floating, the internal oscillator is enabled and the reset active time is fixed at 50 ms typ. (ADM691/93) or 200 ms typ (ADM695). In this mode the OSC IN pin selects between fast ( 100 ms ) and slow ( 1.6 s ) watchdog timeout periods. In both modes, the timeout period immediately after a reset is 1.6 s typical. |
| $\overline{\mathrm{WDO}}$ | Logic Output. The Watchdog Output, $\overline{\mathrm{WDO}}$, goes low if WDI remains either high or low for longer than the watchdog timeout period. $\overline{\mathrm{WDO}}$ is set high by the next transition at WDI. If WDI is unconnected or at midsupply, the watchdog timer is disabled and $\overline{\mathrm{WDO}}$ remains high. $\overline{\mathrm{WDO}}$ also goes high when $\overline{\text { LOW LINE goes low. }}$ |

## PIN CONFIGURATIONS



## PRODUCT SELECTION GUIDE

| Part <br> Number | Nominal Reset <br> Time | Nominal $\mathbf{V C c}_{\text {Cc }}$ <br> Reset Threshold | Nominal Watchdog <br> Timeout Period | Battery Backup <br> Switching | Base Drive <br> Ext PNP | Chip Enable <br> Signals |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| ADM690 | 50 ms | 4.65 V | 1.6 s | Yes | No | No |
| ADM691 | 50 ms or ADJ | 4.65 V | $100 \mathrm{~ms}, 1.6 \mathrm{~s}$, ADJ | Yes | Yes | Yes |
| ADM692 | 50 ms | 4.4 V | Yes | No | No |  |
| ADM693 | 50 ms or ADJ | 4.4 V | $100 \mathrm{~ms}, 1.6 \mathrm{~s}$, ADJ | Yes | Yes | Yes |
| ADM694 | 200 ms | 4.65 V | 1.6 s | No | No |  |
| ADM695 | 200 ms or ADJ | 4.65 V | $100 \mathrm{~ms}, 1.6 \mathrm{~s}$, ADJ | Yes | Yes | Yes |

## CIRCUIT INFORMATION

## Battery Switchover Section

The battery switchover circuit compares $\mathrm{V}_{\mathrm{CC}}$ to the $\mathrm{V}_{\mathrm{BATT}}$ input, and connects $V_{\text {Out }}$ to whichever is higher. Switchover occurs when $\mathrm{V}_{\mathrm{CC}}$ is 50 mV higher than $\mathrm{V}_{\mathrm{BATT}}$ as $\mathrm{V}_{\mathrm{CC}}$ falls, and when $V_{C C}$ is 70 mV greater than $\mathrm{V}_{\text {BATt }}$ as $\mathrm{V}_{\mathrm{CC}}$ rises. This 20 mV of hysteresis prevents repeated rapid switching if $\mathrm{V}_{\mathrm{CC}}$ falls very slowly or remains nearly equal to the battery voltage.


Figure 1. Battery Switchover Schematic
During normal operation with $\mathrm{V}_{\mathrm{CC}}$ higher than $\mathrm{V}_{\mathrm{BATT}}, \mathrm{V}_{\mathrm{CC}}$ is internally switched to $\mathrm{V}_{\text {OUt }}$ via an internal PMOS transistor switch. This switch has a typical on-resistance of $1.5 \Omega$ and can supply up to 100 mA at the $\mathrm{V}_{\text {OUt }}$ terminal. $\mathrm{V}_{\text {OUt }}$ is normally used to drive a RAM memory bank which may require instantaneous currents of greater than 100 mA . If this is the case then a bypass capacitor should be connected to $\mathrm{V}_{\text {OUT }}$. The capacitor will provide the peak current transients to the RAM. A capacitance value of $0.1 \mu \mathrm{~F}$ or greater may be used.

If the continuous output current requirement at $\mathrm{V}_{\text {OUT }}$ exceeds 100 mA or if a lower $\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\text {OUT }}$ voltage differential is desired, an external PNP pass transistor may be connected in parallel with the internal transistor. The BATT ON output (ADM691/ ADM693/ADM695) can directly drive the base of the external transistor.
A $20 \Omega$ MOSFET switch connects the $\mathrm{V}_{\text {BATT }}$ input to $\mathrm{V}_{\text {OUt }}$ during battery backup. This MOSFET has very low input-tooutput differential (dropout voltage) at the low current levels required for battery back up of CMOS RAM or other low power CMOS circuitry. The supply current in battery back up is typically $0.6 \mu \mathrm{~A}$.

The ADM690/ADM691/ADM694/ADM695 operates with battery voltages from 2.0 V to 4.25 V and the ADM692/ADM693 operates with battery voltages from 2.0 V to 4.0 V . High value capacitors, either standard electrolytic or the farad size double layer capacitors, can also be used for short-term memory back up. A small charging current of typically $10 \mathrm{nA}(0.1 \mu \mathrm{~A} \mathrm{max})$ flows out of the $V_{\text {BATt }}$ terminal. This current is useful for maintaining rechargeable batteries in a fully charged condition. This extends the life of the back up battery by compensating for its self discharge current. Also note that this current poses no problem when lithium batteries are used for back up since the maximum charging current $(0.1 \mu \mathrm{~A})$ is safe for even the smallest lithium cells.
If the battery-switchover section is not used, $\mathrm{V}_{\text {BATt }}$ should be connected to GND and $\mathrm{V}_{\mathrm{OUT}}$ should be connected to $\mathrm{V}_{\mathrm{CC}}$.

## POWER FAIL RESET OUTPUT

$\overline{\text { RESET }}$ is an active low output which provides a $\overline{\text { RESET }}$ signal to the Microprocessor whenever $\mathrm{V}_{\mathrm{CC}}$ is at an invalid level.
When $\mathrm{V}_{\mathrm{CC}}$ falls below the reset threshold the $\overline{\mathrm{RESET}}$ output is forced low. The nominal reset voltage threshold is 4.65 V
(ADM690/ADM691/ADM694/ADM695) or 4.4 V (ADM692/ ADM693).


Figure 2. Power Fail Reset Timing
On power-up RESET will remain low for $50 \mathrm{~ms}(200 \mathrm{~ms}$ for ADM694 and ADM695) after $\mathrm{V}_{\mathrm{CC}}$ rises above the appropriate reset threshold. This allows time for the power supply and microprocessor to stabilize. On power-down, the RESET output remains low with $\mathrm{V}_{\mathrm{CC}}$ as low as 1 V . This ensures that the microprocessor is held in a stable shutdown condition.
This $\overline{\text { RESET }}$ active time is adjustable on the ADM691/ ADM693/ADM695 by using an external oscillator or by connecting an external capacitor to the OSC IN pin. Refer to Table I and Figure 4.
The guaranteed minimum and maximum thresholds of the ADM690/ADM691/ADM694/ADM695 are 4.5 V and 4.73 V , while the guaranteed thresholds of the ADM692/ADM693 are 4.25 V and 4.48 V . The ADM690/ADM691/ADM694/ADM695 is, therefore, compatible with 5 V supplies with a $+10 \%,-5 \%$ tolerance while the ADM692/ADM693 is compatible with $5 \mathrm{~V} \pm$ $10 \%$ supplies. The reset threshold comparator has approximately 50 mV of hysteresis. The response time of the reset voltage comparator is less than $1 \mu \mathrm{~s}$. If glitches are present on the $\mathrm{V}_{\mathrm{CC}}$ line which could cause spurious reset pulses, then $\mathrm{V}_{\mathrm{CC}}$ should be decoupled close to the device.
In addition to $\overline{\text { RESET }}$ the ADM691/ADM693/ADM695 contain an active high RESET output. This is the complement of $\overline{\text { RESET }}$ and is intended for processors requiring an active high RESET signal.

## Watchdog Timer RESET

The watchdog timer circuit monitors the activity of the microprocessor in order to check that it is not stalled in an indefinite loop. An output line on the processor is used to toggle the Watchdog Input (WDI) line. If this line is not toggled within the selected timeout period, a RESET pulse is generated. The nominal watchdog timeout period is preset at 1.6 seconds on the ADM690/ADM692/ADM694. The ADM691/ADM693/ADM695 may be configured for either a fixed "short" 100 ms or a "long" 1.6 second timeout period or for an adjustable timeout period. If the "short" period is selected, some systems may be unable to service the watchdog timer immediately after a reset, so the ADM691/ADM693/ADM695 automatically selects the "long" timeout period directly after a reset is issued. The watchdog timer is restarted at the end of reset, whether the reset was caused by lack of activity on WDI or by $\mathrm{V}_{\mathrm{CC}}$ falling below the reset threshold.
The normal (short) timeout period becomes effective following the first transition of WDI after RESET has gone inactive. The watchdog timeout period restarts with each transition on the WDI pin. To ensure that the watchdog timer does not time out, either a high-to-low or low-to-high transition on the WDI pin must occur at or less than the minimum timeout period. If WDI remains permanently either high or low, reset pulses will be issued after each "long" timeout period ( 1.6 s ). The watchdog monitor can be deactivated by floating the Watchdog Input (WDI) or by connecting it to midsupply.


Figure 3. Watchdog Timeout Period and Reset Active Time

Table I. ADM691, ADM693, ADM695 Reset Pulse Width and Watchdog Timeout Selections

|  |  | Watchdog Timeout Period |  | Reset Active Period |  |
| :--- | :--- | :--- | :--- | :--- | :--- |
| OSC SEL |  |  | Immediately <br> After Reset | ADM691/ADM693 | ADM695 |
| Low | OSC IN | Normal | 4096 CLKS | 512 CLKS | 2048 CLKS |
| Low | External Clock Input | 1024 CLKS | $400 \mathrm{~ms} \times \mathrm{C} / 47 \mathrm{pF}$ | $1.6 \mathrm{~s} \times \mathrm{C} / 47 \mathrm{pF}$ | $200 \mathrm{~ms} \times \mathrm{C} / 47 \mathrm{pF}$ |
| Floating or High | External Capacitor | Low | 100 ms | 1.6 s | 50 ms |
| Floating or High | Floating or High | 1.6 s | 1.6 s | 50 ms | 200 ms |

NOTE
With the OSC SEL pin low, OSC IN can be driven by an external clock signal, or an external capacitor can be connected between OSC IN and GND. The nominal internal oscillator frequency is 10.24 kHz . The nominal oscillator frequency with external capacitor is: $\mathrm{F}_{\mathrm{Osc}}(\mathrm{Hz})=184,000 / \mathrm{C}(\mathrm{pF})$.

The watchdog timeout period is fixed at 1.6 seconds, and the reset pulse width is fixed at 50 ms on the ADM690/ADM692. On the ADM694 the watchdog timeout period is also 1.6 sec onds but the reset pulse width is fixed at 200 ms . The ADM691/ADM693/ADM695 allow these times to be adjusted as shown in Table I. Figure 4 shows the various oscillator configurations which can be used to adjust the reset pulse width and watchdog timeout period.

The internal oscillator is enabled when OSC SEL is high or floating. In this mode, OSC IN selects between the 1.6 second and 100 ms watchdog timeout periods. With OSC IN connected high or floating, the 1.6 second timeout period is selected; while with it connected low, the 100 ms timeout period is selected. In either case, immediately after a reset, the timeout period is 1.6 seconds. This gives the microprocessor time to reinitialize the system. If OSC IN is low, then the 100 ms watchdog period becomes effective after the first transition of WDI. The software should be written such that the I/0 port driving WDI is left in its power-up reset state until the initialization routines are completed and the microprocessor is able to toggle WDI at the minimum watchdog timeout period of 70 ms .

## Watchdog Output (WDO)

The Watchdog Output WDO (ADM691/ADM693/ADM695) provides a status output which goes low if the watchdog timer "times out" and remains low until set high by the next transition on the Watchdog Input. $\overline{\mathrm{WDO}}$ is also set high when $\mathrm{V}_{\mathrm{CC}}$ goes below the reset threshold.


Figure 4a. External Clock Source


Figure 4b. External Capacitor


Figure 4c. Internal Oscillator (1.6 Second Watchdog)


Figure 4d. Internal Oscillator (100 ms Watchdog)

## $\overline{\mathrm{CE}}$ Gating and RAM Write Protection (ADM691/ADM693/

 ADM695)The ADM691/ADM693/ADM695 products include memory protection circuitry which ensures the integrity of data in memory by preventing write operations when $\mathrm{V}_{\mathrm{CC}}$ is at an invalid level. There are two additional pins, $\overline{\mathrm{CE}}_{\mathrm{IN}}$ and $\overline{\mathrm{CE}}_{\text {OUT }}$, which may be used to control the Chip Enable or Write inputs of CMOS RAM. When $V_{C C}$ is present, $\overline{\mathrm{CE}}_{\mathrm{OUT}}$ is a buffered replica of $\overline{\mathrm{CE}}_{\mathrm{IN}}$, with a 5 ns propagation delay. When $\mathrm{V}_{\mathrm{CC}}$ falls below the reset voltage threshold or $\mathrm{V}_{\mathrm{BATT}}$, an internal gate forces $\overline{\mathrm{CE}}_{\text {OUT }}$ high, independent of $\overline{\mathrm{CE}}_{\mathrm{IN}}$.
$\overline{\mathrm{CE}}_{\text {Out }}$ typically drives the $\overline{\mathrm{CE}}, \overline{\mathrm{CS}}$, or write input of battery backed up CMOS RAM. This ensures the integrity of the data in memory by preventing write operations when $\mathrm{V}_{\mathrm{CC}}$ is at an invalid level. Similar protection of EEPROMs can be achieved by using the $\overline{\mathrm{CE}}_{\text {OUT }}$ to drive the store or write inputs.
If the 5 ns typical propagation delay of $\overline{\mathrm{CE}}_{\mathrm{OUT}}$ is excessive, connect $\overline{\mathrm{CE}}_{\text {IN }}$ to GND and use the resulting $\overline{\mathrm{CE}}_{\text {OUT }}$ to control a high speed external logic gate.


Figure 5. Chip Enable Gating

$\mathrm{t}_{1}=$ RESET TIME.
V1 = RESET VOLTAGE THRESHOLD LOW
V2 $=$ RESET VOLTAGE THRESHOLD HIGH HYSTERESIS = V2-V1

Figure 6. Chip Enable Timing

## Power Fail Warning Comparator

An additional comparator is provided for early warning of failure in the microprocessor's power supply. The Power Fail Input (PFI) is compared to an internal +1.3 V reference. The Power Fail Output $(\overline{\mathrm{PFO}})$ goes low when the voltage at PFI is less than 1.3 V. Typically PFI is driven by an external voltage divider which senses either the unregulated dc input to the system's 5 V regulator or the regulated 5 V output. The voltage divider ratio can be chosen such that the voltage at PFI falls below 1.3 V several milliseconds before the +5 V power supply falls below the reset threshold. $\overline{\mathrm{PFO}}$ is normally used to interrupt the microprocessor so that data can be stored in RAM and the shut down procedure executed before power is lost.


Figure 7. Power Fail Comparator

Table II. Input and Output Status In Battery Backup Mode

| Signal | Status |
| :---: | :---: |
| $\mathrm{V}_{\text {OUT }}$ | $\mathrm{V}_{\text {OUT }}$ is connected to $\mathrm{V}_{\text {BATT }}$ via an internal PMOS switch. |
| $\overline{\text { RESET }}$ | Logic low. |
| RESET | Logic high. The open circuit output voltage is equal to $\mathrm{V}_{\text {OUT }}$. |
| LOW LINE | Logic low. |
| BATT ON | Logic high. The open circuit voltage is equal to $V_{\text {OUT }}$. |
| WDI | WDI is ignored. It is internally disconnected from the internal pull-up resistor and does not source or sink current as long as its input voltage is between GND and $\mathrm{V}_{\text {OUt }}$ The input voltage does not affect supply current. |
| $\overline{\text { WDO }}$ | Logic high. The open circuit voltage is equal to $\mathrm{V}_{\text {Out }}$. |
| PFI | The Power Fail Comparator is turned off and has no effect on the Power Fail Output. |
| $\overline{\mathrm{PFO}}$ | Logic low. |
| $\overline{\mathrm{CE}}_{\mathrm{IN}}$ | $\overline{\mathrm{CE}}_{\text {IN }}$ is ignored. It is internally disconnected from its internal pull-up and does not source or sink current as long as its input voltage is between GND and $\mathrm{V}_{\text {OUT }}$. The input voltage does not affect supply current. |
| $\overline{\mathrm{CE}}_{\text {OUT }}$ | Logic high. The open circuit voltage is equal to $\mathrm{V}_{\text {OUT }}$. |
| OSC IN | OSC IN is ignored. |
| OSC SEL | OSC SEL is ignored. |

## FEATURES

## Superior Upgrade for MAX696/MAX697 <br> Specified Over Temperature <br> Adjustable Low Line Voltage Monitor <br> Power OK/Reset Time Delay <br> Reset Assertion Down to 1 V V cc <br> Watchdog Timer-100 ms, $\mathbf{1 . 6} \mathrm{s}$, or Adjustable <br> Low Switch On Resistance <br> $1.5 \Omega$ Normal, $20 \Omega$ in Backup <br> 600 nA Standby Current <br> Automatic Battery Backup Switching (ADM696) <br> Fast On-Board Gating of Chip Enable Signals (ADM697) <br> Voltage Monitor for Power Fail or Low Battery Warning

APPLICATIONS
Microprocessor Systems
Computers
Controllers
Intelligent Instruments
Automotive Systems
Critical $\mu \mathrm{P}$ Power Monitoring

## GENERAL DESCRIPTION

The ADM696/ADM697 supervisory circuits offer complete single chip solutions for power supply monitoring and battery control functions in microprocessor systems. These functions include $\mu \mathrm{P}$ reset, backup-battery switchover, watchdog timer, CMOS RAM write protection, and power failure warning.

The ADM696/ADM697 are available in 16-pin DIP and small outline packages and provide the following functions:

1. Power-On Reset output during power-up, power-down and brownout conditions. The RESET voltage threshold is adjustable using an external voltage divider. The $\overline{\text { RESET }}$ output remains operational with $\mathrm{V}_{\mathrm{CC}}$ as low as 1 V .
2. A Reset pulse if the optional watchdog timer has not been toggled within a specified time.
3. Separate watchdog timeout and low line status outputs.
4. Adjustable reset and watchdog timeout periods.
5. A 1.3 V threshold detector for power fail warning, low battery detection, or to monitor a power supply other than $\mathrm{V}_{\mathrm{CC}}$.
6. Battery backup switching for CMOS RAM, CMOS microprocessor or other low power logic (ADM696).
7. Write protection of CMOS RAM or EEPROM (ADM697).

## FUNCTIONAL BLOCK DIAGRAMS



The ADM696/ADM697 is fabricated using an advanced epitaxial CMOS process combining low power consumption ( 5 mW ), extremely fast Chip Enable gating ( 5 ns ) and high reliability. $\overline{\text { RESET }}$ assertion is guaranteed with $\mathrm{V}_{\mathrm{CC}}$ as low as 1 V . In addition, the power switching circuitry is designed for minimal voltage drop thereby permitting increased output current drive of up to 100 mA without the need for an external pass transistor.

| Parameter | Min | Typ | Max | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ Operating Voltage Range <br> $\mathrm{V}_{\mathrm{BATT}}$ Operating Voltage Range | $\begin{aligned} & 3.0 \\ & 2.0 \end{aligned}$ |  | $\begin{aligned} & 5.5 \\ & \mathrm{~V}_{\mathrm{CC}}-0.3 \end{aligned}$ |  |  |
| BATTERY BACKUP SWITCHING (ADM696) $V_{\text {OUT }}$ Output Voltage <br> $\mathrm{V}_{\text {Out }}$ in Battery Backup Mode Supply Current (excludes I $\mathrm{IOUT}^{\text {) }}$ Supply Current in Battery Backup Mode Battery Standby Current ( $+=$ Discharge, $-=$ Charge) <br> Battery Switchover Threshold $\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{BATt}}$ Battery Switchover Hysteresis BATT ON Output Voltage BATT ON Output Short Circuit Current | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}-0.05 \\ & \mathrm{v}_{\mathrm{CC}}-0.5 \\ & \mathrm{~V}_{\mathrm{BATT}}-0.05 \\ & \\ & -0.1 \\ & -1 \\ & \\ & 0.5 \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}-0.025 \\ & \mathrm{~V}_{\mathrm{CC}}-0.25 \\ & \mathrm{~V}_{\mathrm{BATT}}-0.02 \\ & 1 \\ & 0.6 \\ & \\ & 70 \\ & 50 \\ & 20 \\ & 7 \\ & 1 \end{aligned}$ | $\begin{aligned} & 1.95 \\ & 1 \\ & +0.02 \\ & +0.02 \\ & \\ & 0.4 \\ & 25 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~mA} \\ & \mu \mathrm{~A} \\ & \mu \mathrm{~A} \\ & \mu \mathrm{~A} \\ & \mathrm{mV} \\ & \mathrm{mV} \\ & \mathrm{mV} \\ & \mathrm{~V} \\ & \mathrm{~mA} \\ & \mu \mathrm{~A} \end{aligned}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{OUT}}=1 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OUT}} \leqslant 100 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OUT}}=250 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{CC}}<\mathrm{V}_{\mathrm{BATT}}-0.2 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{OUT}}=100 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{CC}}=0 \mathrm{~V}, \mathrm{~V}_{\text {BATT }}=2.8 \mathrm{~V} \\ & 5.5 \mathrm{~V}>\mathrm{V}_{\mathrm{CC}}>\mathrm{V}_{\mathrm{BATT}}+0.2 \mathrm{~V} \\ & \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \end{aligned}$ <br> Power-Up <br> Power-Down $\mathrm{I}_{\mathrm{SINK}}=1.6 \mathrm{~mA}$ <br> BATT ON $=\mathrm{V}_{\text {OUT }}=2.4 \mathrm{~V}$ Sink Current <br> BATT ON $=\mathrm{V}_{\mathrm{OUT}}, \mathrm{V}_{\mathrm{CC}}=0 \mathrm{~V}$, <br> Source Current |
| RESET AND WATCHDOG TIMER <br> Low Line Threshold ( $\mathrm{LL}_{\mathrm{IN}}$ ) <br> Reset Timeout Delay <br> Watchdog Timeout Period, Internal Oscillator <br> Watchdog Timeout Period, External Clock <br> Minimum WDI Input Pulse Width <br> RESET Output Voltage @ $\mathrm{V}_{\mathrm{CC}}=+1 \mathrm{~V}$ <br> RESET, $\overline{\text { RESET Output Voltage }}$ <br> LOW LINE, $\overline{\text { WDO }}$ Output Voltage <br> Output Short Circuit Source Current <br> WDI Input Threshold <br> Logic Low <br> Logic High <br> WDI Input Current | 1.25 35 1.0 70 4032 960 50 3.5 3.5 1 3.5 -50 | 1.3 <br> 50 <br> 1.6 <br> 100 <br> 4 <br> 3 <br> 20 <br> $-15$ | 1.35 70 2.25 140 4097 1025 200 0.4 0.4 0.4 25 0.8 50 | V <br> ms <br> s <br> ms <br> Cycles Cycles ns <br> mV <br> V <br> V <br> V <br> V <br> V <br> $\mu \mathrm{A}$ <br> V <br> V <br> $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V},+3 \mathrm{~V} \\ & \mathrm{OSC} \text { SEL }=H I G H, \mathrm{~V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \text { Long Period, } \mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & {\text { Short Period, } \mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}}^{\text {Long Period }} \\ & \text { Short Period } \\ & \mathrm{V}_{\mathrm{IL}}=0.4, \mathrm{~V}_{\mathrm{IH}}=3.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}=5 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{SINK}}=10 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{CC}}=1 \mathrm{~V} \\ & \mathrm{I}_{\text {SINK }}=400 \mu \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}=2 \mathrm{~V}, \mathrm{~V}_{\mathrm{BATT}}=0 \mathrm{~V} \\ & \mathrm{I}_{\text {SINK }}=1.6 \mathrm{~mA}, 3 \mathrm{~V}<\mathrm{V}_{\mathrm{CC}}<5.5 \mathrm{~V} \\ & \mathrm{I}_{\text {SOURCE }}=1 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{CC}}=5 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{SINK}}=1.6 \mathrm{~mA}, \\ & \mathrm{I}_{\text {SOURCE }}=1 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{CC}}=5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CC}}=5 \mathrm{~V}^{1} \\ & \\ & \mathrm{WDI}=\mathrm{V}_{\mathrm{OUT}},\left(\mathrm{~V}_{\mathrm{CC}}\right) \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \mathrm{WDI}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \hline \end{aligned}$ |
| POWER FAIL DETECTOR <br> PFI Input Threshold PFI-LL ${ }_{\text {IN }}$ Threshold Difference PFI Input Current $\mathrm{LL}_{\text {IN }}$ Input Current PFO Output Voltage <br> $\overline{\text { PFO }}$ Short Circuit Source Current | $\begin{aligned} & 1.2 \\ & -50 \\ & -25 \\ & -50 \\ & \\ & 3.5 \\ & 1 \end{aligned}$ | $\begin{aligned} & 1.3 \\ & \pm 15 \\ & \pm 0.01 \\ & \pm 0.01 \\ & \\ & 3 \end{aligned}$ | $\begin{aligned} & 1.4 \\ & +50 \\ & +25 \\ & +50 \\ & 0.4 \\ & 25 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{mV} \\ & \mathrm{nA} \\ & \mathrm{nA} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mu \mathrm{~A} \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=+3 \mathrm{~V},+5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CC}}=+3 \mathrm{~V},+5 \mathrm{~V} \\ & \\ & \mathrm{I}_{\mathrm{SINK}}=1.6 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{SOURCE}}=1 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{CC}}=5 \mathrm{~V} \\ & \mathrm{PFI}=\text { Low, } \mathrm{PFO}=0 \mathrm{~V} \end{aligned}$ |
| CHIP ENABLE GATING (ADM697) $\overline{\mathrm{CE}}_{\text {IN }}$ Threshold $\overline{\mathrm{CE}}_{\text {IN }}$ Pullup Current $\overline{\mathrm{CE}}_{\text {Out }}$ Output Voltage $\overline{\mathrm{CE}}$ Propagation Delay | $\begin{aligned} & 3.0 \\ & v_{C C}-0.5 \end{aligned}$ | 3 5 | 0.8 0.4 25 | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mu \mathrm{~A} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~ns} \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{IL}} \\ & \mathrm{~V}_{\mathrm{IH}}, \mathrm{~V}_{\mathrm{CC}}=5 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{SINK}}=1.6 \mathrm{~mA} \\ & \mathrm{I}_{\text {SOURCE }}=800 \mu \mathrm{~A} \end{aligned}$ |
| OSCILLATOR <br> OSC IN Input Current <br> OSC SEL Input Pullup Current <br> OSC IN Frequency Range <br> OSC IN Frequency with Ext. Capacitor | 0 | $\begin{aligned} & \pm 2 \\ & 5 \\ & 4 \end{aligned}$ | 250 | $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ <br> kHz <br> kHz | $\begin{aligned} & \text { OSC SEL }=0 \mathrm{~V} \\ & \text { OSC SEL }=0 \mathrm{~V}, \mathrm{C}_{\mathrm{OSC}}=47 \mathrm{pF} \end{aligned}$ |

## NOTE

${ }^{1}$ WDI is a three-level input which is internally biased to $38 \%$ of $\mathrm{V}_{\mathrm{cc}}$ and has an input impedance of approximately $125 \mathrm{k} \Omega$.
Specifications subject to change without notice.

| ABSOLUTE MAXIMUM RATINGS* |  |
| :---: | :---: |
|  |  |
| $\mathrm{V}_{\mathrm{CC}}$ | -0.3 V to +6 V |
| $V_{\text {batt }}$ | . -0.3 V to +6 V |
| All Other Inputs | -0.3 V to $\mathrm{V}_{\text {OUT }}+0.5 \mathrm{~V}$ |
| Input Current |  |
| $\mathrm{V}_{\mathrm{CC}}$ | . 200 mA |
| $\mathrm{V}_{\text {batt }}$ | 50 mA |
| GND | 20 mA |
| Digital Output Current | 20 mA |
| Power Dissipation, N-16 DIP | 600 mW |
| $\theta_{\text {JA }}$ Thermal Impedance | $135^{\circ} \mathrm{C} / \mathrm{W}$ |
| Power Dissipation, Q-16 DIP | 600 mW |
| $\theta_{\text {JA }}$ Thermal Impedance | $100^{\circ} \mathrm{C} / \mathrm{W}$ |

Power Dissipation, R-16 SOIC . . . . . . . . . . . . . . . . 600 mW
$\theta_{\mathrm{JA}}$ Thermal Impedance . . . . . . . . . . . . . . . . . . $110^{\circ} \mathrm{C} / \mathrm{W}$
Operating Temperature Range
Industrial (A Version) . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Extended (S Version) . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 s ) . . . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Vapor Phase (60 s) . . . . . . . . . . . . . . . . . . . . . . $+215^{\circ} \mathrm{C}$
Infrared (15 s) . . . . . . . . . . . . . . . . . . . . . . . . . $+220^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum ratings for extended periods of time may affect device reliability.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD696/ADM697 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


ORDERING GUIDE

| Model | Temperature Range | Package Option ${ }^{\star}$ |
| :--- | :--- | :---: |
| ADM696AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| ADM696AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16$ |
| ADM696AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| ADM696SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| ADM697AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| ADM697AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16$ |
| ADM697AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| ADM697SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |

[^230]PIN CONFIGURATIONS



## PIN FUNCTION DESCRIPTION

|  | Pin No. |  |  |
| :---: | :---: | :---: | :---: |
| Mnemonic | ADM696 | ADM697 | Function |
| $\mathrm{V}_{\mathrm{CC}}$ | 3 | 3 | Power Supply Input +3 V to +5 V . |
| $\mathrm{V}_{\text {batt }}$ | 1 | - | Backup Battery Input. Connect to Ground if a backup battery is not used. |
| $\mathrm{V}_{\text {OUT }}$ | 2 | - | Output Voltage, $\mathrm{V}_{\mathrm{CC}}$ or $\mathrm{V}_{\mathrm{BATT}}$ is internally switched to $\mathrm{V}_{\text {OUT }}$ depending on which is at the highest potential. $\mathrm{V}_{\text {OUT }}$ can supply up to 100 mA to power CMOS RAM. Connect $\mathrm{V}_{\text {OUt }}$ to $\mathrm{V}_{\mathrm{CC}}$ if $\mathrm{V}_{\text {OUT }}$ and $\mathrm{V}_{\text {BATt }}$ are not used. |
| GND | 4 | 5 | 0 V . Ground reference for all signals. |
| $\overline{\text { RESET }}$ | 15 | 15 | Logic Output. $\overline{\text { RESET }}$ goes low whenever $\mathrm{LL}_{\mathrm{IN}}$ falls below 1.3 V or when $\mathrm{V}_{\mathrm{CC}}$ falls below the $\mathrm{V}_{\text {BATT }}$ input voltage. $\overline{\operatorname{RESET}}$ remains low for 50 ms after $\mathrm{LL}_{\text {IN }}$ goes above 1.3 V , RESET also goes low for 50 ms if the watchdog timer is enabled but not serviced within its timeout period. The RESET pulse width can be adjusted as shown in Table I. |
| WDI | 11 | 11 | Watchdog Input, WDI is a three level input. If WDI remains either high or low for longer than the watchdog timeout period, $\overline{\text { RESET }}$ pulses low and $\overline{\mathrm{WDO}}$ goes low. The timer resets with each transition at the WDI input. The watchdog timer is disabled when WDI is left floating or is driven to midsupply. |
| PFI | 9 | 9 | Power Fail Input. PFI is the noninverting input to the Power Fail Comparator when PFI is less than 1.3 V , PFO goes low. Connect PFI to GND or $\mathrm{V}_{\text {Out }}$ when not used. See Figure 1. |
| $\overline{\text { PFO }}$ | 10 | 10 | Power Fail Output. $\overline{\mathrm{PFO}}$ is the output of the Power Fail Comparator. It goes low when PFI is less than 1.3 V . The comparator is turned off and $\overline{\mathrm{PFO}}$ goes low when $\mathrm{V}_{\mathrm{CC}}$ is below $\mathrm{V}_{\text {batt }}$. |
| $\overline{\mathrm{CE}}_{\text {IN }}$ | - | 13 | Logic Input. The input to the CE gating circuit. Connect to GND or $\mathrm{V}_{\text {Out }}$ if not used. |
| $\overline{\mathrm{CE}}_{\text {OUT }}$ | - | 12 | Logic Output. $\overline{\mathrm{CE}}_{\text {OUT }}$ is a gated version of the $\overline{\mathrm{CE}}_{\text {IN }}$ signal. $\overline{\mathrm{CE}}_{\text {OUT }}$ tracks $\overline{\mathrm{CE}}_{\mathrm{IN}}$ when $\mathrm{LL}_{\mathrm{IN}}$ is above 1.3 V . If $\mathrm{LL}_{\text {IN }}$ is below $1.3 \mathrm{~V}, \overline{\mathrm{CE}}_{\text {OUT }}$ is forced high. |
| BATT ON | 5 | - | Logic Output. BATT ON goes high when $\mathrm{V}_{\text {OUT }}$ is internally switched to the $\mathrm{V}_{\text {BATT }}$ input. It goes low when $\mathrm{V}_{\mathrm{OUT}}$ is internally switched to $\mathrm{V}_{\mathrm{CC}}$. The output typically sinks 7 mA and can directly drive the base of an external PNP transistor to increase the output current above the 100 mA rating of $\mathrm{V}_{\text {OUT }}$. |
| LOW LINE | 6 | 6 | Logic Output. $\overline{\text { LOW LINE }}$ goes low when $L_{\text {IN }}$ falls below 1.3 V . It returns high as soon as $\mathrm{LL}_{\text {IN }}$ rises above 1.3 V |
| RESET | 16 | 16 | Logic Output. RESET is an active high output. It is the inverse of RESET. |
| OSC SEL | 8 | 8 | Logic Oscillator Select Input. When OSC SEL is unconnected or driven high, the internal oscillator sets the reset time delay and watchdog timeout period. When OSC SEL is low, the external oscillator input, OSC IN, is enabled. OSC SEL has a $3 \mu \mathrm{~A}$ internal pullup. See Table I and Figure 4. |
| OSC IN | 7 | 7 | Logic Oscillator Input. When OSC SEL is low, OSC IN can be driven by an external clock to adjust both the reset delay and the watchdog timeout period. The timing can also be adjusted by connecting an external capacitor to this pin. See Table I and Figure 4. When OSC SEL is high or floating, OSC IN selects between fast and slow watchdog timeout periods. |
| $\overline{\text { WDO }}$ | 14 | 14 | Logic Output. The Watchdog Output, $\overline{\mathrm{WDO}}$, goes low if WDI remains either high or low for longer than the watchdog timeout period. $\overline{\mathrm{WDO}}$ is set high by the next transition at WDI. If WDI is unconnected or at midsupply, $\overline{\text { WDO }}$ remains high. $\overline{\text { WDO }}$ also goes high when LOW LINE goes low. |
| NC | 12 | 2 | No Connect. It should be left open. |
| $L_{L}{ }_{\text {IN }}$ | 13 | 4 | Voltage Sensing Input. The voltage on the low line input, LLIN, is compared with a 1.3 V reference voltage. This input is normally used to monitor the power supply voltage. The output of the comparator generates a LOW LINE output signal. It also generates a RESET/RESET output. |
| TEST | - | 1 | This is a special test pin using during device manufacture. It should be connected to GND. |

## ADM696/ADM697

## CIRCUIT INFORMATION

## Battery-Switchover Section (ADM696)

The battery switchover circuit compares $\mathrm{V}_{\mathrm{CC}}$ to the $\mathrm{V}_{\mathrm{BATT}}$ input, and connects $V_{\text {OUT }}$ to whichever is higher. Switchover occurs when $\mathrm{V}_{\mathrm{CC}}$ is 50 mV higher than $\mathrm{V}_{\mathrm{BATt}}$ as $\mathrm{V}_{\mathrm{CC}}$ falls, and when $\mathrm{V}_{\mathrm{CC}}$ is 70 mV greater than $\mathrm{V}_{\mathrm{BATt}}$ as $\mathrm{V}_{\mathrm{CC}}$ rises. This 20 mV of hysteresis prevents repeated rapid switching if $\mathrm{V}_{\mathrm{CC}}$ falls very slowly or remains nearly equal to the battery voltage.
During normal operation with $\mathrm{V}_{\mathrm{CC}}$ higher than $\mathrm{V}_{\mathrm{BATT}}, \mathrm{V}_{\mathrm{CC}}$ is internally switched to $\mathrm{V}_{\text {OUt }}$ via an internal PMOS transistor switch. This switch has a typical on resistance of $1.5 \Omega$ and can supply up to 100 mA at the $\mathrm{V}_{\text {OUT }}$ terminal. $\mathrm{V}_{\text {OUT }}$ is normally used to drive a RAM memory bank which may require instantaneous currents of greater than 100 mA . If this is the case, then a bypass capacitor should be connected to $\mathrm{V}_{\text {OUT }}$. The capacitor will provide the peak current transients to the RAM. A capacitance value of $0.1 \mu \mathrm{~F}$ or greater may be used.
If the continuous output current requirement at $\mathrm{V}_{\text {OUT }}$ exceeds 100 mA or if a lower $\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\text {OUT }}$ voltage differential is desired, an external PNP pass transistor may be connected in parallel with the internal transistor. The BATT ON output can directly drive the base of the external transistor.
A $20 \Omega$ MOSFET switch connects the $V_{\text {BATT }}$ input to $V_{\text {OUT }}$ during battery backup. This MOSFET has very low input-tooutput differential (dropout voltage) at the low current levels required for battery backup of CMOS RAM or other low power CMOS circuitry. The supply current in battery backup is typically $0.6 \mu \mathrm{~A}$.
The ADM696 operates with battery voltages from 2.0 V to $\mathrm{V}_{\mathrm{CC}}$ -0.3 V ). High value capacitors, either standard electrolytic or the farad-size double layer capacitors, can also be used for shortterm memory backup. A small charging current of typically $10 \mathrm{nA}(0.1 \mu \mathrm{~A} \max )$ flows out of the $\mathrm{V}_{\mathrm{BATt}}$ terminal. This current is useful for maintaining rechargeable batteries in a fully charged condition. This extends the life of the backup battery by compensating for its self discharge current. Also note that this current poses no problem when lithium batteries are used for backup since the maximum charging current $(0.1 \mu \mathrm{~A})$ is safe for even the smallest lithium cells.
If the battery-switchover section is not used, $\mathrm{V}_{\text {BATt }}$ should be connected to GND and $\mathrm{V}_{\text {OUT }}$ should be connected to $\mathrm{V}_{\mathrm{CC}}$.


Figure 1. Battery Switchover Schematic

## Low Line RESET OUTPUT

$\overline{\text { RESET }}$ is an active low output which provides a $\overline{\text { RESET }}$ signal to the microprocessor whenever the Low Line Input $\left(L_{\text {IN }}\right)$ is below 1.3 V . The $\mathrm{LL}_{\text {IN }}$ input is normally used to monitor the power supply voltage. An internal timer holds $\overline{\text { RESET }}$ low for 50 ms after the voltage on $\mathrm{LL}_{\text {IN }}$ rises above 1.3 V . This is intended as a power-on RESET signal for the processor. It allows time for the power supply and microprocessor to stabilize. On power-down, the RESET output remains low with $\mathrm{V}_{\mathrm{CC}}$ as low as 1 V . This ensures that the microprocessor is held in a stable shutdown condition.

The $\mathrm{LL}_{\text {IN }}$ comparator has approximately 12 mV of hysteresis for enhanced noise immunity.
In addition to $\overline{\text { RESET, an active high RESET output is also }}$ available. This is the complement of RESET and is useful for processors requiring an active high RESET.


Figure 2. Power-Fail Reset Timing

## Watchdog Timer RESET

The watchdog timer circuit monitors the activity of the microprocessor in order to check that it is not stalled in an indefinite loop. An output line on the processor is used to toggle the Watchdog Input (WDI) line. If this line is not toggled within the selected timeout period, a RESET pulse is generated. The ADM696/ADM697 may be configured for either a fixed "short" 100 ms or a "long" 1.6 second timeout period or for an adjustable timeout period. If the "short" period is selected some systems may be unable to service the watchdog timer immediately after a reset, so a "long" timeout is automatically initiated directly after a reset is issued. The watchdog timer is restarted at the end of Reset, whether the Reset was caused by lack of activity on WDI or by $\mathrm{LL}_{\mathrm{IN}}$ falling below the reset threshold.
The normal (short) timeout period becomes effective following the first transition of WDI after RESET has gone inactive. The watchdog timeout period restarts with each transition on the WDI pin. To ensure that the watchdog timer does not time out, either a high-to-low or low-to high transition on the WDI pin must occur at or less than the minimum timeout period. If WDI remains permanently either high or low, reset pulses will be issued after each timeout period ( 1.6 s ). The watchdog monitor can be deactivated by floating the Watchdog Input (WDI) or by connecting it to midsupply.

Table I. ADM696, ADM697 Reset Pulse Width and Watchdog Timeout Selections

| OSC SEL |  | Watchdog Timeout Period |  | Reset Active Period |
| :--- | :--- | :--- | :--- | :--- |
|  | OSC IN | Normal | Immediately After Reset |  |
| Low | External Clock Input | 1024 CLKS | 4096 CLKS | 512 CLKS |
| Low | External Capacitor | $400 \mathrm{~ms} \times \mathrm{C} / 47 \mathrm{pF}$ | $1.6 \mathrm{~s} \times \mathrm{C} / 47 \mathrm{pF}$ | $200 \mathrm{~ms} \times \mathrm{C} / 47 \mathrm{pF}$ |
| Floating or High | Low | 100 ms | 1.6 s | 50 ms |
| Floating or High | Floating or High | 1.6 s | 1.6 s | 50 ms |

NOTE
With the OSC SEL pin low, OSC IN can be driven by an external clock signal, or an external capacitor can be connected between OSC IN and GND. The nominal internal oscillator frequency is 10.24 kHz . The nominal oscillator frequency with external capacitor is: $\mathrm{F}_{\mathrm{osc}}(\mathrm{Hz})=184,000 / \mathrm{C}$ ( pF ).


Figure 3. Watchdog Timeout Period and Reset Active Time
The watchdog timeout period defaults to 1.6 s and the reset pulse width defaults to 50 ms but these times to be adjusted as shown in Table I. Figure 4 shows the various oscillator configurations which can be used to adjust the reset pulse width and watchdog timeout period.
The internal oscillator is enabled when OSC SEL is high or floating. In this mode, OSC IN selects between the 1.6 second and 100 ms watchdog timeout periods. In either case, immediately after a reset the timeout period is 1.6 s . This gives the microprocessor time to reinitialize the system. If OSC IN is low, then the 100 ms watchdog period becomes effective after the first transition of WDI. The software should be written such that the I/O port driving WDI is left in its power-up reset state until the initialization routines are completed and the microprocessor is able to toggle WDI at the minimum watchdog timeout period of 70 ms .


Figure 4b. External Capacitor


Figure 4c. Internal Oscillator (1.6 s Watchdog)


Figure 4d. Internal Oscillator (100 ms Watchdog)

## Watchdog Output ( $\overline{\mathbf{W D O}}$ )

The Watchdog Output $\overline{\mathrm{WDO}}$ provides a status output which goes low if the watchdog timer "times out" and remains low until set high by the next transition on the watchdog input. $\overline{\text { WDO }}$ is also set high when $\mathrm{LL}_{\text {IN }}$ goes below the reset threshold.


Figure 4a. External Clock Source

## CE Gating and RAM Write Protection (ADM697)

The ADM697 contains memory protection circuitry which ensures the integrity of data in memory by preventing write operations when $\mathrm{LL}_{\text {IN }}$ is below the threshold voltage. When $\mathrm{LL}_{\mathrm{IN}}$ is greater than $1.3 \mathrm{~V}, \overline{\mathrm{CE}}_{\mathrm{OUT}}$ is a buffered replica of $\overline{\mathrm{CE}}_{\mathrm{IN}}$, with a 5 ns propagation delay. When $\mathrm{LL}_{\mathrm{IN}}$ falls below the 1.3 V threshold, an internal gate forces $\overline{\mathrm{CE}}_{\mathrm{OUT}}$ high, independent of $\overline{\mathrm{CE}}_{\mathrm{IN}}$.
$\overline{\mathrm{CE}}_{\text {OUt }}$ typically drives the $\mathrm{CE}, \mathrm{CS}$, or Write input of battery backed up CMOS RAM. This ensures the integrity of the data in memory by preventing write operations when $V_{C C}$ is at an invalid level.
If the 5 ns typical propagation delay of $\overline{\mathrm{CE}}_{\mathrm{OUT}}$ is excessive, connect $\overline{\mathrm{CE}}_{\text {IN }}$ to GND and use the resulting $\overline{\mathrm{CE}}_{\text {OUT }}$ to control a high speed external logic gate.


Figure 5. Chip Enable Gating


Figure 6. Chip Enable Timing

## Power Fail Warning Comparator

An additional comparator is provided for early warning of failure in the microprocessor's power supply. The Power Fail Input ( PFI ) is compared to an internal +1.3 V reference. The Power

Fail Output ( $\overline{\mathrm{PFO}}$ ) goes low when the voltage at PFI is less than 1.3 V . Typically PFI is driven by an external voltage divider which senses either the unregulated dc input to the system's 5 V regulator or the regulated 5 V output. The voltage divider ratio can be chosen such that the voltage at PFI falls below 1.3 V several milliseconds before the +5 V power supply falls below the reset threshold. $\overline{\mathrm{PFO}}$ is normally used to interrupt the microprocessor so that data can be stored in RAM and the shut-down procedure executed before power is lost.


Figure 7. Power Fail Comparator
Table II. Input and Output Status In Battery Backup Mode

| Signal | Status |
| :---: | :---: |
| $\mathrm{V}_{\text {OUT }}$ | (ADM696) $\mathrm{V}_{\text {OUT }}$ is connected to $\mathrm{V}_{\text {BATt }}$ via an internal PMOS switch. |
| $\overline{\text { RESET }}$ | Logic low. |
| RESET | Logic high. The open circuit output voltage is equal to $V_{\text {Out }}$. |
| LOW LINE | Logic low. |
| BATT ON | (ADM696) Logic high. The open circuit voltage is equal to $V_{\text {OUT }}$. |
| WDI | WDI is ignored. It is internally disconnected from the internal pullup resistor and does not source or sink current as long as its input voltage is between GND and $\mathrm{V}_{\text {OUT }}$. The input voltage does not affect supply current. |
| $\overline{\mathrm{WDO}}$ | Logic high. The open circuit voltage is equal to $V_{\text {OUT }}$. |
| PFI | The Power Fail Comparator is turned off and has no effect on the Power Fail Output. |
| $\overline{\text { PFO }}$ | Logic low. |
| $\overline{\mathrm{CE}}_{\mathrm{IN}}$ | $\overline{\mathrm{CE}}_{\text {IN }}$ is ignored. It is internally disconnected from its internal pullup and does not source or sink current as long as its input voltage is between GND and $\mathrm{V}_{\text {OUT }}$. The input voltage does not affect supply current. |
| $\overline{\mathrm{CE}}_{\text {OUT }}$ | Logic high. The open circuit voltage is equal to $V_{\text {OUT }}$. |
| OSC IN | OSC IN is ignored. |
| OSC SEL | OSC SEL is ignored. |



Figure 8. $V_{\text {Out }}$ vs. $I_{\text {Out }}$ Normal Operation


Figure 9. $V_{\text {Out }}$ vs. Battery Backup


Figure 10. PFI Input Threshold vs. Temperature


Figure 11. RESET Active Time vs. Temperature


Figure 12. $\overline{R E S E T}$ Output Voltage vs. Supply Voltage


Figure 13. $\overline{R E S E T}$ Timeout Delay vs. $V_{C C}$

Microprocessor

## FEATURES

Superior Upgrade for MAX698/MAX699
Guaranteed RESET Assertion with $\mathbf{V}_{\mathbf{c c}}=1 \mathrm{~V}$
Low 0.6 mA Supply Current
Precision 4.65 V Voltage Monitor
Power OK/Reset Time Delay
Watchdog Timer
Minimum Component Count
Performance Specified over Temperature

## APPLICATIONS

Microprocessor Systems
Computers
Controllers
Intelligent Instruments
Automotive Systems
Critical $\mu$ P Power Monitoring

## GENERAL DESCRIPTION

The ADM698/ADM699 supervisory circuits provide power supply monitoring and watchdog timing for microprocessor systems.
The ADM698 monitors the $5 \mathrm{~V} \mathrm{~V}_{\mathrm{CC}}$ power supply and generates a RESET pulse during power up, power down and during low voltage "Brown Out" conditions. The RESET output is guaranteed to be functional (logic low) with $\mathrm{V}_{\mathrm{CC}}$ as low as 1 V .

The ADM699 features an identical monitoring circuit as in the ADM698 plus an additional watchdog timer input to monitor microprocessor activity. The $\overline{\text { RESET output is forced low if the }}$ watchdog input is not toggled within the 1 second watchdog timeout period.
Both parts are available in 8-pin plastic DIP and 16-lead SOIC packages. The 16 -lead SOIC contains additional outputs RESET (without inversion) and Watchdog Output WDO (ADM699 only).

FUNCTIONAL BLOCK DIAGRAM

*WDI (ADM699 ONLY)
RESET (SOIC ONLY)
WDO (ADM699 SOIC ONLY)

## TYPICAL APPLICATION CIRCUIT



\begin{tabular}{|c|c|c|c|c|c|}
\hline Parameter \& Min \& Typ \& Max \& Units \& Test Conditions/Comments \\
\hline \(\mathrm{V}_{\mathrm{CC}}\) Operating Voltage Range Supply Current \& 3.0 \& 0.6 \& \[
\begin{aligned}
\& 5.5 \\
\& 1.95
\end{aligned}
\] \& \[
\begin{aligned}
\& \mathrm{V} \\
\& \mathrm{~mA}
\end{aligned}
\] \& \\
\hline Power-Down Reset Assertion Power-Up Reset Deassertion Reset Threshold Hysteresis Reset Active Time \& \[
4.5
\]
\[
140
\] \& \[
\begin{aligned}
\& 4.65 \\
\& 40 \\
\& 200
\end{aligned}
\] \& \[
\begin{aligned}
\& 4.73 \\
\& 4.73 \\
\& \\
\& 280
\end{aligned}
\] \& \begin{tabular}{l}
V \\
V \\
mV \\
ms
\end{tabular} \& \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V}\) \\
\hline Watchdog Timeout Period (ADM699) Minimum WDI Input Pulse Width \& \[
\begin{aligned}
\& 1.0 \\
\& 50
\end{aligned}
\] \& 1.6 \& 2.25 \& \[
\begin{aligned}
\& \mathrm{s} \\
\& \mathrm{~ns}
\end{aligned}
\] \& \[
\begin{aligned}
\& \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{~V}_{\mathrm{CC}}=+5 \mathrm{~V} \\
\& \mathrm{~V}_{\mathrm{IL}}=0.4, \mathrm{~V}_{\mathrm{IH}}=3.5 \mathrm{~V}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
RESET Output Voltage RESET Output Voltage ( \(\mathrm{V}_{\mathrm{CC}}=1 \mathrm{~V}\) ) \\
RESET and \(\overline{\text { WDO }}\) Output Voltage \\
RESET Output Short Circuit Current
\end{tabular} \& 3.5
3.5 \& 4

25 \& $$
\begin{aligned}
& 0.4 \\
& 200 \\
& 0.4
\end{aligned}
$$ \& \[

$$
\begin{aligned}
& \mathrm{V} \\
& \mathrm{mV} \\
& \mathrm{~V} \\
& \mathrm{~V} \\
& \mathrm{~V} \\
& \mathrm{~mA}
\end{aligned}
$$

\] \& \[

$$
\begin{aligned}
& \mathrm{I}_{\text {SINK }}=1.6 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CC}}=4.4 \mathrm{~V} \\
& \mathrm{I}_{\text {SINK }}=10 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{CC}}=1.0 \mathrm{~V} \\
& \mathrm{I}_{\text {SOURCE }}=1 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{CC}}=5 \mathrm{~V} \\
& \mathrm{I}_{\text {SINK }}=1.6 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CC}}=5 \mathrm{~V} \\
& \mathrm{I}_{\text {SOURCE }}=1 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{CC}}=4.4 \mathrm{~V} \\
& \text { Output Sink Current }
\end{aligned}
$$
\] <br>

\hline | WDI Input Threshold (ADM699) |
| :--- |
| Logic Low |
| Logic High |
| WDI Input Current | \& \[

$$
\begin{aligned}
& 3.5 \\
& -50
\end{aligned}
$$

\] \& \[

$$
\begin{aligned}
& 20 \\
& -20
\end{aligned}
$$
\] \& 0.8

50 \& | V |
| :--- |
| $\mu \mathrm{A}$ |
| $\mu \mathrm{A}$ | \& \[

$$
\begin{aligned}
& \text { WDI }=\mathrm{V}_{\mathrm{CC}}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\
& \mathrm{WDI}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}
\end{aligned}
$$
\] <br>

\hline
\end{tabular}

Specifications subject to change without notice.

ABSOLUTE MAXIMUM RATINGS*
( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)

All Other Inputs . . . . . . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{CC}}+0.3 \mathrm{~V}$
Power Dissipation 8-Pin DIP . . . . . . . . . . . . . . . . . 500 mW
$\theta_{\mathrm{JA}}$, Thermal Impedance . . . . . . . . . . . . . . . . $+120^{\circ} \mathrm{C} / \mathrm{W}$
Power Dissipation 16-Pin SOIC . . . . . . . . . . . . . . . 375 mW
$\theta_{\mathrm{JA}}$, Thermal Impedance...............$+110^{\circ} \mathrm{C} / \mathrm{W}$
Power Dissipation 8-Pin Cerdip . . . . . . . . . . . . . . . 500 mW
$\theta_{\mathrm{JA}}$, Thermal Impedance . . . . . . . . . . . . . . . $+125^{\circ} \mathrm{C} / \mathrm{W}$
Operating Temperature Range
Industrial (A Version) . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Extended (S Version) . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 secs) . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Vapor Phase ( 60 secs) . . . . . . . . . . . . . . . . . . . . $+215^{\circ} \mathrm{C}$
Infrared (15 secs) . . . . . . . . . . . . . . . . . . . . . . . $+220^{\circ} \mathrm{C}$
Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum ratings for extended periods of time may affect device reliability.

## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Option |
| :--- | :--- | :--- |
| ADM698AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| ADM698AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16$ |
| ADM698AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |
| ADM698SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |
| ADM699AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| ADM699AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16$ |
| ADM699AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |
| ADM699SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |

[^231]
## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the ADM698/ADM699 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


PIN FUNCTION DESCRIPTION

| Mnemonic | Function |
| :--- | :--- |
| $\mathrm{V}_{\mathrm{CC}}$ | +5 V Power Supply Input. |
| GND | 0 V. Ground reference for all signals. |
| $\overline{\text { RESET }}$ | Logic Output. $\overline{\text { RESET }}$ goes low whenever $\mathrm{V}_{\mathrm{CC}}$ <br> falls below the reset voltage threshold $(4.65 \mathrm{~V}$ |
| typ). $\overline{\text { RESET }}$ remains low for a minimum of |  |
| 140 ms after $\mathrm{V}_{\mathrm{CC}}$ returns to $5 \mathrm{~V} . \overline{\mathrm{RESET}}$ also goes |  |
| low for a minimum of 140 ms if the watchdog |  |

low for a minimum of 140 ms if the watchdog timer is enabled but not serviced within its timeout period.
Watchdog Input. WDI is a three level input. If WDI remains either high or low for longer than the watchdog timeout period, $\overline{\operatorname{RESET}}$ pulses low and WDO goes low. The timer resets with each transition on the WDI line. The watchdog timer may be disabled if WDI is left floating or is driven to midsupply.
(SOIC packages only) Logic Output. RESET is an active high output. It is the inverse of RESET.
(SOIC ADM699 only) Logic Output. The Watchdog Output, WDO, goes low if WDI remains either high or low for longer than the watchdog timeout period. $\overline{\mathrm{WDO}}$ is set high by the next transition at WDI. If WDI is unconnected or at midsupply, the watchdog timer is disabled and $\overline{\text { WDO }}$ remains high.

## TYPICAL PERFORMANCE CURVES



Figure 1. RESET Output Voltage vs. $V_{c c}$

## PIN CONFIGURATION (DIP)



PIN CONFIGURATION (SOIC)



Figure 2. RESET Active Time vs. Temperature


Figure 3. RESET Voltage Threshold vs. Temperature

## CIRCUIT INFORMATION

## Power Fail RESET

A precision voltage detector monitors $\mathrm{V}_{\mathrm{CC}}$ and generates a RESET output to hold the microprocessor's Reset line low when $\mathrm{V}_{\mathrm{CC}}$ falls below the reset threshold ( 4.65 V ) (see Figure 4). The reset voltage threshold is set to accommodate a $5 \%$ variation on $\mathrm{V}_{\mathrm{CC}}$. The voltage detector has 40 mV hysteresis to ensure that glitches on $\mathrm{V}_{\mathrm{CC}}$ do not activate the RESET output.
On power up, an internal monostable holds $\overline{\text { RESET }}$ low for 140 ms after $\mathrm{V}_{\mathrm{CC}}$ rises above the reset threshold. This allows the power supply to stabilize on power up and also prevents repeated toggling of RESET even if the 5 V power drops out and recovers with each power line cycle. In order to prevent mistriggering due to transient voltage spikes, it is recommended that a $0.1 \mu \mathrm{~F}$ capacitor be connected at the $\mathrm{V}_{\mathrm{CC}}$ pin.
The $\overline{\text { RESET }}$ output is guaranteed to remain low with $\mathrm{V}_{\mathrm{CC}}$ as low as 1 V . This holds the microprocessor in a stable shutdown condition as the power supply comes up.
On the 16-lead SOIC package, an active high RESET output is also provided. This is the complement of RESET and is intended for microprocessors requiring an active high signal.


Figure 4. Watchdog Timeout Period vs. Temperature

## Watchdog Timer (ADM699 Only)

The watchdog timer input (WDI) monitors an I/O line from the $\mu \mathrm{P}$ system. The $\mu \mathrm{P}$ must toggle this input once every $1.6 \mathrm{sec}-$ onds to verify correct software execution. Failure to toggle the line indicates that the $\mu \mathrm{P}$ system is not correctly executing its program and may be tied up in an endless loop. If this happens, a reset pulse is generated to initialize the processor.
The WDI input is a three level input and will recognize a low-to- high or a high-to-low transition on its input. The watchdog timer is reset by each WDI transition and then begins its timeout period. If the WDI pin remains either high or low, reset pulses will be issued every 1.6 seconds typically. If the watchdog timer is not needed, the WDI input should be left floating. The Watchdog Output ( $\overline{\mathrm{WDO}}$ ) (SOIC package Only) provides watchdog status information. It is driven low if WDI is not toggled within the watchdog timeout period. It goes high at the next WDI transition. It is also set high when $\mathrm{V}_{\mathrm{CC}}$ falls below the reset threshold.


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Figure 5. Watchdog Timeout Period and Reset Active Time

## FEATURES

Meets EIA RS-485 Standard
$30 \mathrm{Mb} / \mathrm{s}$ Data Rate
Single +5 V Supply
-7 V to +12 V Bus Common-Mode Range
High Speed, Low Power BiCMOS
Thermal Shutdown Protection
Short Circuit Protection
Zero Skew Driver
Driver Propagation Delay: 10 ns
Receiver Propagation Delay: 25 ns
High Z Outputs with Power Off
Superior Upgrade for LTC1485

## APPLICATIONS

Low Power RS-485 Systems

## DTE-DCE Interface

Packet Switching
Local Area Networks
Data Concentration
Data Multiplexers
Integrated Services Digital Network (ISDN)

## DESCRIPTION

The ADM1485 is a differential line transceiver suitable for high speed bidirectional data communication on multipoint bus transmission lines. It is designed for balanced data transmission and complies with both EIA Standards RS-485 and RS-422. The part contains a differential line driver and a differential line receiver. Both the driver and the receiver may be enabled independently. When disabled, the outputs are tristated.
The ADM1485 operates from a single +5 V power supply. Excessive power dissipation caused by bus contention or by output shorting is prevented by a thermal shutdown circuit. This feature forces the driver output into a high impedance state if during fault conditions a significant temperature increase is detected in the internal driver circuitry.

Up to 32 transceivers may be connected simultaneously on a bus, but only one driver should be enabled at any time. It is important therefore that the remaining disabled drivers do not load the bus. To ensure this, the ADM1485 driver features high output impedance when disabled and also when powered down.

This minimizes the loading effect when the transceiver is not being utilized. The high impedance driver output is maintained over the entire common-mode voltage range from -7 V to +12 V .
The receiver contains a fail safe feature which results in a logic high output state if the inputs are unconnected (floating).
The ADM1485 is fabricated on BiCMOS, an advanced mixed technology process combining low power CMOS with fast switching bipolar technology. All inputs and outputs contain protection against ESD; all driver outputs feature high source and sink current capability. An epitaxial layer is used to guard against latch-up.
The ADM1485 features extremely fast switching speeds. Minimal driver propagation delays permit transmission at data rates up to $30 \mathrm{Mbits} / \mathrm{s}$ while low skew minimizes EMI interference.
The part is fully specified over the commercial and industrial temperature range and is available in an 8-pin DIL/ SOIC package.

| Parameter | Min | Typ | Max | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DRIVER |  |  |  |  |  |
| Differential Output Voltage, $\mathrm{V}_{\mathrm{OD}}$ |  |  | 5.0 | V | $\mathbf{R}=\infty$, Figure 1 |
|  | 2.0 |  | 5.0 | V | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{R}=50 \Omega$ (RS-422), Figure 1 |
|  | 1.5 |  | 5.0 | V | $\mathrm{R}=27 \Omega$ (RS-485), Figure 1 |
| $\mathrm{V}_{\text {OD3 }}$ | 1.5 |  | 5.0 | V | $\mathrm{V}_{\text {TST }}=-7 \mathrm{~V}$ to +12 V , Figure 2 |
| $\Delta\left\|\mathrm{V}_{\text {OD }}\right\|$ for Complementary Output States |  |  | 0.2 | V | $\mathrm{R}=27 \Omega$ or $50 \Omega$, Figure 1 |
| Common-Mode Output Voltage $\mathrm{V}_{\mathrm{OC}}$ |  |  | 3 | V | $\mathrm{R}=27 \Omega$ or $50 \Omega$, Figure 1 |
| $\Delta\left\|\mathrm{V}_{\text {Oc }}\right\|$ for Complementary Output States |  |  | 0.2 | V | $\mathrm{R}=27 \Omega$ or $50 \Omega$ |
| Output Short Circuit Current ( $\mathrm{V}_{\text {OUT }}=\mathrm{High}$ ) | 35 |  | 250 | mA | $-7 \mathrm{~V} \leq \mathrm{V}_{\mathrm{O}} \leq+12 \mathrm{~V}$ |
| Output Short Circuit Current ( $\mathrm{V}_{\text {OUT }}=$ Low) | 35 |  | 250 | mA | $-7 \mathrm{~V} \leq \mathrm{V}_{\mathrm{O}} \leq+12 \mathrm{~V}$ |
| CMOS Input Logic Threshold Low, $\mathrm{V}_{\text {INL }}$ |  |  | 0.8 | V |  |
| CMOS Input Logic Threshold High, $\mathrm{V}_{\text {INH }}$ | 2.0 |  |  | V |  |
| Logic Input Current (DE, DI) |  |  | $\pm 1.0$ | $\mu \mathrm{A}$ |  |
| RECEIVER |  |  |  |  |  |
| Differential Input Threshold Voltage, $\mathrm{V}_{\text {TH }}$ | -0.2 |  | +0.2 | V | $-7 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CM}} \leq+12 \mathrm{~V}$ |
| Input Voltage Hysteresis, $\Delta \mathrm{V}_{\text {TH }}$ |  | 70 |  | mV | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ |
| Input Resistance | 12 |  |  | k $\Omega$ | $-7 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CM}} \leq+12 \mathrm{~V}$ |
| Input Current (A, B) |  |  | +1 | mA | $\mathrm{V}_{\mathrm{IN}}=12 \mathrm{~V}$ |
|  |  |  | -0.8 | mA | $\mathrm{V}_{\mathrm{IN}}=-7 \mathrm{~V}$ |
| Logic Enable Input Current ( $\overline{\mathrm{RE}}$ ) |  |  | $\pm 1$ | $\mu \mathrm{A}$ |  |
| CMOS Output Voltage Low, $\mathrm{V}_{\mathrm{OL}}$ |  |  | 0.4 | V | $\mathrm{I}_{\text {OUT }}=+4.0 \mathrm{~mA}$ |
| CMOS Output Voltage High, $\mathrm{V}_{\mathrm{OH}}$ | 4.0 |  |  | V | $\mathrm{I}_{\text {OUT }}=-4.0 \mathrm{~mA}$ |
| Short Circuit Output Current | 7 |  | 85 | mA | $\mathrm{V}_{\text {OUT }}=\mathrm{GND}$ or $\mathrm{V}_{\mathrm{CC}}$ |
| Tristate Output Leakage Current |  |  | $\pm 1.0$ | $\mu \mathrm{A}$ | $0.4 \mathrm{~V} \leq \mathrm{V}_{\text {OUT }} \leq+2.4 \mathrm{~V}$ |
| POWER SUPPLY CURRENT |  |  |  |  |  |
| $\mathrm{I}_{\mathrm{CC}}$ (Outputs Enabled) |  | 1.35 | 2.2 | mA | Outputs Unloaded, Digital Inputs $=$ GND or $\mathrm{V}_{\text {cc }}$ |
| $\mathrm{I}_{\mathrm{CC}}$ (Outputs Disabled) |  | 0.7 | 1 | mA | Outputs Unloaded, Digital Inputs = GND or $\mathrm{V}_{\mathrm{CC}}$ |

Specifications subject to change without notice.

## TIMING SPECIFICATIONS ${ }_{v_{c c}}=+5 \mathrm{~V} \pm 5 \%$. All specifications $\mathrm{T}_{\mathrm{mu}}$ to $\mathrm{T}_{\mathrm{mux}}$ unless otherwise noted.)

| Parameter | Min | Typ | Max | Units | Test Conditions/ Comments |
| :--- | :--- | :--- | :--- | :--- | :--- |
| DRIVER |  |  |  |  |  |
| Propagation Delay Input to Output $T_{P L H}, T_{P H L}$ | 2 | 10 | 15 | ns | $\mathrm{R}_{\mathrm{L}}$ Diff $=54 \Omega \mathrm{C}_{\mathrm{L} 1}=\mathrm{C}_{\mathrm{L} 2}=100 \mathrm{pF}$, Figure 3 |
| Driver O/P to $\overline{\mathrm{O} / \mathrm{P}} \mathrm{T}_{\mathrm{SKEW}}$ |  | 0 | 5 | ns | $\mathrm{R}_{\mathrm{L}}$ Diff $=54 \Omega \mathrm{C}_{\mathrm{L} 1}=\mathrm{C}_{\mathrm{L} 2}=100 \mathrm{pF}$, Figure 3 |
| Driver Rise/Fall Time $\mathrm{T}_{\mathrm{R}}, \mathrm{T}_{\mathrm{F}}$ |  | 2 | 10 | ns | $\mathrm{R}_{\mathrm{L}}$ Diff $=54 \Omega \mathrm{C}_{\mathrm{L} 1}=\mathrm{C}_{\mathrm{L} 2}=100 \mathrm{pF}$, Figure 3 |
| Driver Enable to Output Valid |  | 10 | 25 | ns |  |
| Driver Disable Timing |  | 10 | 25 | ns |  |
| RECEIVER |  |  |  |  |  |
| Propagation Delay Input to Output $\mathrm{T}_{\mathrm{PLH}}, \mathrm{T}_{\mathrm{PHL}}$ | 18 | 25 | 40 | ns | $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$, Figure 5 |
| Skew $\left\|\mathrm{T}_{\mathrm{PLH}}-\mathrm{T}_{\mathrm{PHL}}\right\|$ |  | 0 | 5 | ns |  |
| Receiver Enable $\mathrm{T}_{\mathrm{EN} 1}$ |  | 15 | 25 | ns | Figure 6 |
| Receiver Disable $\mathrm{T}_{\mathrm{EN} 2}$ |  | 15 | 25 | ns | Figure 6 |

[^232]
## ABSOLUTE MAXIMUM RATINGS*

( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise noted)
$\mathrm{V}_{\mathrm{CC}}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . +7 V

Inputs

$$
\text { Driver Input (DI) .. . . . . . . . . }-0.3 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{CC}}+0.3 \mathrm{~V}
$$

$$
\text { Control Inputs (DE, RE) } \ldots . . . .-0.3 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{CC}}+0.3 \mathrm{~V}
$$

$$
\text { Receiver Inputs }(\mathrm{A}, \mathrm{~B}) \ldots \ldots . . ., \ldots-14 \mathrm{~V} \text { to }+14 \mathrm{~V}
$$

Outputs
Driver Outputs
. . . . . . . . . . . . . . . . . . -14 V to +14 V
Receiver Output . . . . . . . . . . . . . -0.5 V to $\mathrm{V}_{\mathrm{CC}}+0.5 \mathrm{~V}$
Power Dissipation 8-Pin DIP . . . . . . . . . . . . . . . . . 500 mW
$\theta_{\mathrm{JA}}$, Thermal Impedance . . . . . . . . . . . . . . . $+130^{\circ} \mathrm{C} / \mathrm{W}$
Power Dissipation 8-Pin SOIC . . . . . . . . . . . . . . . . 450 mW
$\theta_{\mathrm{JA}}$, Thermal Impedance . . . . . . . . . . . . . . . $+170^{\circ} \mathrm{C} / \mathrm{W}$
Power Dissipation 8-Pin Cerdip . . . . . . . . . . . . . . . 500 mW
$\theta_{\mathrm{JA}}$, Thermal Impedance . . . . . . . . . . . . . . . . $+125^{\circ} \mathrm{C} / \mathrm{W}$
Operating Temperature Range
Commercial (J Version) . . . . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Industrial (A Version) . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 sec ) . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Vapour Phase ( 60 sec ) . . . . . . . . . . . . . . . . . . . . $+215^{\circ} \mathrm{C}$
Infrared (15 sec) . . . . . . . . . . . . . . . . . . . . . . . . $+220^{\circ} \mathrm{C}$
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum ratings for extended periods of time may affect device reliability.

Table I. Transmitting

|  | INPUTS |  | OUTPUTS |  |
| :--- | :--- | :--- | :--- | :--- |
| $\overline{\mathbf{R E}}$ | DE | DI | $\mathbf{B}$ | $\mathbf{A}$ |
| $\mathbf{X}$ | 1 | 1 | 0 | 1 |
| $\mathbf{X}$ | 1 | 0 | 1 | 0 |
| $\mathbf{X}$ | 0 | X | Z | Z |

Table II. Receiving

|  | INPUTS |  | OUTPUT |
| :--- | :--- | :--- | :--- |
| $\overline{\mathbf{R E}}$ | $\mathbf{D E}$ | $\mathbf{A - B}$ | $\mathbf{R O}$ |
| 0 | 0 | $\geq+0.2 \mathrm{~V}$ | 1 |
| 0 | 0 | $\leq-0.2 \mathrm{~V}$ | 0 |
| 0 | 0 | Inputs Open | 1 |
| 1 | 0 | X | Z |

PIN FUNCTION DESCRIPTION

| Pin | Mnemonic | Function |
| :--- | :--- | :--- |
| 1 | RO | Receiver Output. When enabled if A $>$ B by <br> 200 mV, then RO = High. If A $<$ B by <br> 200 mV, then RO = Low. <br> Receiver Output Enable. A low level enables <br> the receiver output, RO. A high level places <br> it in a high impedance state. <br> Driver Output Enable. A high level enables <br> the driver differential outputs, A and B. A <br> low level places it in a high impedance state. |
| 3 | DE | Driver Input. When the driver is enabled a <br> logic Low on DI forces A low and B high <br> while a logic High on DI forces A high and B <br> low. <br> Ground Connection, 0 V. |
| 5 | DI | GND |
| 6 | ANoninverting Receiver Input A/Driver <br> Output A. <br> Inverting Receiver Input B/Driver Output B. <br> 7 | B |
| 8 | $V_{\text {CC }}$ | Power Supply, 5 V $\pm 5 \%$. |

## PIN CONFIGURATION



## ORDERING GUIDE

| Model | Temperature Range | Package Option» |
| :--- | :--- | :--- |
| ADM1485JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| ADM1485JR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{R}-8$ |
| ADM1485AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| ADM1485AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-8$ |
| ADM1485AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-8$ |

*For outline information see Package Information section.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the ADM1485 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


## Test Circuits



Figure 1. Driver Voltage Measurement Test Circuit


Figure 2. Driver Voltage Measurement Test Circuit 2


Figure 3. Driver Propagation Delay Test Circuit


Figure 4. Driver Enable/Disable Test Circuit


Figure 5. Receiver Propagation Delay Test Circuit


Figure 6. Receiver Enable/Disable Test Circuit

## Switching Characteristics



Figure 7. Driver Propagation Delay, Rise/Fall Timing


Figure 8. Driver Enable/Disable Timing


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Figure 9. Receiver Propagation Delay


Figure 10. Receiver Enable/Disable Timing


Figure 11. Receiver Output Low Voltage vs. Output Current


Figure 14. Receiver Output Low Voltage vs. Temperature


Figure 17. Driver Output Low Voltage vs. Output Current


Figure 12. Receiver Output High Voltage vs. Output Current


Figure 15. Driver Differential Output Voltage vs. Output Current


Figure 18. Driver Output High Voltage vs. Output Current


Figure 13. Receiver Output High Voltage vs. Temperature


Figure 16. Driver Differential Output Voltage vs. Temperature, $R_{L}=54 \Omega$


Figure 19. Supply Current vs. Temperature


Figure 20. Receiver $t_{P L H}-t_{P H L}$ vs. Temperature


Figure 21. Driver Skew vs. Temperature


Figure 24. Driver/Receiver Propagation Delays Low to High


Figure 22. Unloaded Driver Differential Outputs


Figure 25. Driver/Receiver Propagation Delays High to Low


Figure 26. Typical RS-485 Network

## ADM1485

## APPLICATIONS INFORMATION

## Differential Data Transmission

Differential data transmission is used to reliably transmit data at high rates over long distances and through noisy environments. Differential transmission nullifies the effects of ground shifts and noise signals which appear as common-mode voltages on the line. There are two main standards approved by the Electronics Industries Association (EIA) which specify the electrical characteristics of transceivers used in differential data transmission.
The RS-422 standard specifies data rates up to 10 MBaud and line lengths up to 4000 ft . A single driver can drive a transmission line with up to 10 receivers.

In order to cater for true multipoint communications, the RS-485 standard was defined. This standard meets or exceeds all the requirements of RS-422 but also allows for up to 32 drivers and 32 receivers to be connected to a single bus. An extended common-mode range of -7 V to +12 V is defined. The most significant difference between RS-422 and RS-485 is the fact that the drivers may be disabled thereby allowing more than one ( 32 in fact) to be connected to a single line. Only one driver should be enabled at time, but the RS-485 standard contains additional specifications to guarantee device safety in the event of line contention.

## Cable and Data Rate

The transmission line of choice for RS-485 communications is a twisted pair. Twisted pair cable tends to cancel common-mode noise and also causes cancellation of the magnetic fields generated by the current flowing through each wire, thereby, reducing the effective inductance of the pair.
The ADM1485 is designed for bidirectional data communications on multipoint transmission lines. A typical application showing a
multipoint transmission network is illustrated in Figure 26. An RS-485 transmission line can have as many as 32 transceivers on the bus. Only one driver can transmit at a particular time but multiple receivers may be enabled simultaneously.
As with any transmission line, it is important that reflections are minimized. This may be achieved by terminating the extreme ends of the line using resistors equal to the characteristic impedance of the line. Stub lengths of the main line should also be kept as short as possible. A properly terminated transmission line appears purely resistive to the driver.

## Thermal Shutdown

The ADM1485 contains thermal shutdown circuitry which protects the part from excessive power dissipation during fault conditions. Shorting the driver outputs to a low impedance source can result in high driver currents. The thermal sensing circuitry detects the increase in die temperature and disables the driver outputs. The thermal sensing circuitry is designed to disable the driver outputs when a die temperature of $150^{\circ} \mathrm{C}$ is reached. As the device cools, the drivers are re-enabled at $140^{\circ} \mathrm{C}$.

## Propagation Delay

The ADM1485 features very low propagation delay ensuring maximum baud rate operation. The driver is well balanced ensuring distortion free transmission.

Another important specification is a measure of the skew between the complementary outputs. Excessive skew impairs the noise immunity of the system and increases the amount of electromagnetic interference (EMI).

## Receiver Open-Circuit Fail Safe

The receiver input includes a fail-safe feature which guarantees a logic high on the receiver when the inputs are open circuit or floating.

Table III. Comparison of RS-422 and RS-485 Interface Standards

| Specification | RS-422 | RS-485 |
| :--- | :--- | :--- |
| Transmission Type | Differential | Differential |
| Maximum Cable Length | 4000 ft. | 4000 ft. |
| Minimum Driver Output Voltage | $\pm 2 \mathrm{~V}$ | $\pm 1.5 \mathrm{~V}$ |
| Driver Load Impedance | $100 \Omega$ | $54 \Omega$ |
| Receiver Input Resistance | $4 \mathrm{k} \Omega \mathrm{min}$ | $12 \mathrm{k} \Omega \mathrm{min}$ |
| Receiver Input Sensitivity | $\pm 200 \mathrm{mV}$ | $\pm 200 \mathrm{mV}$ |
| Receiver Input Voltage Range | -7 V to +7 V | -7 V to +12 V |
| No of Drivers/Receivers Per Line | $1 / 10$ | $32 / 32$ |

## FEATURES

Eight Single Ended Line Drivers in One Package Meets EIA Standard RS-232E, RS-423A and CCITT V.10/X. 26
Resistor Programmable Slew Rate
Wide Supply Voltage Range
Low Power CMOS
3-State Outputs
TTL/CMOS Compatible Inputs
Output Short Circuit Protection
Available in 28-Pin DIP/PLCC
Low Power Replacement for UC5170C

## APPLICATIONS

High Speed Communication
Computer I-O Ports Peripherals
High Speed Modems
Printers
Logic Level Translation

## GENERAL DESCRIPTION

The ADM5170 is an octal line driver suitable for digital communication systems with data rates up to $116 \mathrm{kB} / \mathrm{s}$. Input TTL or CMOS signal levels are inverted and translated into either EIA RS-232E or RS-423A signal levels depending on the status of the Mode Select inputs MS+ and MS-. With both Mode Select inputs at GND, RS-423 operation is selected while with MS+ connected to $\mathrm{V}_{\mathrm{DD}}$ and MS- connected to $\mathrm{V}_{\mathrm{SS}}, \mathrm{RS}-232$ operation is selected.

The output slew rates may be controlled using an external resistor connected between the SRA (Slew Rate Adjust) pin and GND. Resistor values between $2 \mathrm{k} \Omega$ and $10 \mathrm{k} \Omega$ may be selected giving a slew rate which can be adjusted from $10 \mathrm{~V} / \mu \mathrm{s}$ to $2.2 \mathrm{~V} / \mu \mathrm{s}$. This adjustment of the slew rate allows tailoring of the output characteristics to suit the interface cable being used.
The outputs may be disabled using the $\overline{\mathrm{EN}}$ (Enable Input). This feature permits sharing of a common output line.

The ADM5170 is fabricated on an advanced CMOS process featuring low power consumption. In the disabled state the power consumption reduces from 500 mW to 40 mW . The ADM5170 is available in both 28 -pin DIP and 28 -lead PLCC packages.

FUNCTIONAL BLOCK DIAGRAM


| Inputs  <br> $\overline{\text { EN }}$ Data | Outputs <br> EIA RS-232E | RS-423A |  |
| :--- | :--- | :--- | :--- |
| 0 | 0 | $\left(\mathrm{~V}_{\mathrm{DD}}-3 \mathrm{~V}\right)$ | 5 V to 6 V |
| 0 | 1 | $\left(\mathrm{~V}_{s \mathrm{~s}}-3 \mathrm{~V}\right)$ | -5 V to -6 V |
| 1 | X | High Z | High Z |

[^233]This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

ADM5170-SPEC|F|CATIONS $\begin{aligned} & \left(V_{D 0}=+10 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{s \mathrm{~s}}=-10 \mathrm{~V} \pm 10 \% \mathrm{~V}, \mathrm{MS}+=\mathrm{MS}-=0 \mathrm{~V}, \mathrm{R}_{\text {sRA }}=\right. \\ & \left.10 \mathrm{k} \Omega \text {. All } S \text { Secifications } \mathrm{T}_{\text {mN }} \text { to } \mathrm{T}_{\text {max }} \text { unless otherwise noted. }\right)\end{aligned}$

| Parameter | Min | Typ | Max | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| POWER REQUIREMENTS <br> $V_{D D}$ Range <br> $\mathrm{V}_{\mathrm{ss}}$ Range <br> $\mathrm{I}_{\mathrm{DD}}$ (Disabled) <br> $\mathrm{I}_{\mathrm{DD}}$ (Enabled) <br> $\mathrm{I}_{\mathrm{ss}}$ (Disabled) <br> $\mathrm{I}_{\mathrm{ss}}$ (Enabled) | $\begin{aligned} & 9 \\ & -9 \end{aligned}$ | $\begin{aligned} & 2 \\ & 25 \\ & -2 \\ & -23 \end{aligned}$ | $\begin{aligned} & 15 \\ & -15 \\ & 4 \\ & 36 \\ & -4 \\ & -36 \end{aligned}$ | V <br> V <br> mA <br> mA <br> mA <br> mA | $\begin{aligned} & \overline{\mathrm{EN}}=\mathrm{High}, \\ & \mathrm{R}_{\mathrm{L}}=\infty, \overline{\mathrm{EN}}=0 \mathrm{~V} \\ & \overline{\mathrm{EN}}=\mathrm{High} \\ & \mathrm{R}_{\mathrm{L}}=\infty, \overline{\mathrm{EN}}=0 \mathrm{~V} \end{aligned}$ |
| DIGITAL INPUTS <br> Input Logic Threshold High, $\mathrm{V}_{\text {INH }}$ Input Logic Threshold Low, $\mathrm{V}_{\text {INL }}$ Input Clamp Voltage, $\mathrm{V}_{\text {INK }}$ Input High Level Current, $\mathrm{I}_{\text {INH }}$ Input Low Level Current, $\mathrm{I}_{\text {INL }}$ | $2.0$ $-1$ | -1.1 | $\begin{aligned} & 0.8 \\ & -1.8 \\ & 1 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mu \mathrm{~A} \\ & \mu \mathrm{~A} \end{aligned}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{IN}}=-15 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{INH}}=2.4 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{INL}}=0.4 \mathrm{~V} \end{aligned}$ |
| OUTPUTS <br> RS-423A Outputs <br> High Level Output Voltage <br> Low Level Output Voltage <br> Output Balance, $\mathrm{V}_{\text {BAL }}$ <br> RS-232 Outputs <br> High Level Output Voltage <br> Low Level Output Voltage <br> Off-State Output Current, $\mathrm{I}_{\mathrm{oz}}$ Short Circuit Current, $\mathrm{I}_{\mathrm{OS}}$ | $\begin{aligned} & 5.0 \\ & 5.0 \\ & 4.5 \\ & -5.0 \\ & -5.0 \\ & -4.5 \\ & \\ & 7.0 \\ & 7.0 \\ & -7.0 \\ & -7.0 \\ & -100 \\ & 15 \\ & 15 \end{aligned}$ | $\begin{aligned} & 5.3 \\ & 5.3 \\ & 5.2 \\ & -5.3 \\ & -5.6 \\ & -5.4 \\ & 0.05 \\ & \\ & 7.6 \\ & 7.6 \\ & -7.7 \\ & -7.7 \\ & \\ & 50 \\ & 40 \end{aligned}$ | 6.0 6.0 6.0 -6.0 -6.0 -6.0 0.4 $V_{\mathrm{DD}}$ $\mathrm{V}_{\mathrm{DD}}$ $\mathrm{V}_{\mathrm{Ss}}$ $\mathrm{V}_{\mathrm{ss}}$ 100 100 100 | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mu \mathrm{~A} \\ & \mathrm{~mA} \\ & \mathrm{~mA} \end{aligned}$ | $\begin{aligned} & \overline{\mathrm{EN}}=0.8 \mathrm{~V}, \mathrm{MS}+=\mathrm{MS}-=0 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{L}}=\infty, \mathrm{V}_{\mathrm{IN}}=0.8 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{L}}=3 \mathrm{k} \Omega, \mathrm{~V}_{\mathrm{IN}}=0.8 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{L}}=450 \Omega, \mathrm{~V}_{\mathrm{IN}}=0.8 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{L}}=\infty, \mathrm{V}_{\mathrm{IN}}=2.0 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{L}}=3 \mathrm{k} \Omega, \mathrm{~V}_{\mathrm{IN}}=2.0 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{L}}=450 \Omega, \mathrm{~V}_{\mathrm{IN}}=2.0 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{L}}=450 \Omega, \mathrm{~V}_{\mathrm{BAL}}=\mathrm{V}_{\text {oH }}-\mathrm{V}_{\mathrm{OL}} \\ & \mathrm{EN}=0.8 \mathrm{~V}, \mathrm{MS}+=\mathrm{V}_{\mathrm{DD}}, \mathrm{MS}-=\mathrm{V}_{\mathrm{SS}} \\ & \mathrm{R}_{\mathrm{L}}=\infty, \mathrm{V}_{\mathrm{IN}}=0.8 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{L}}=3 \mathrm{k} \Omega, \mathrm{~V}_{\mathrm{IN}}=0.8 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{L}}=\infty, \mathrm{V}_{\mathrm{IN}}=2.0 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{L}}=3 \mathrm{k} \Omega, \mathrm{~V}_{\mathrm{IN}}=2.0 \mathrm{~V} \\ & \mathrm{EN}=2.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{o}}= \pm 6 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=15 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=-15 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V}, \mathrm{EN}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{IN}}=5 \mathrm{~V}, \overline{\mathrm{EN}}=0 \mathrm{~V} \end{aligned}$ |

Specifications subject to change without notice.

TIMING CHARACTERISTICS $\begin{aligned} & \left(V_{D D}=+10 \mathrm{~V} \pm 10 \%, V_{S S}=-10 \mathrm{~V} \pm 10 \%, \mathrm{MS}+=\mathrm{MS}-=0 \mathrm{~V} \text {. All Specifications } \mathrm{T}_{\mathrm{MIN}} \text { to } \mathrm{T}_{\text {max }}\right.\end{aligned}$

| Parameter | Min | Typ | Max | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Output Slew Rate | 6.65 | 10 | 14 | V/ $\mu \mathrm{s}$ | Fig 1, Fig 2. $\mathrm{R}_{\text {SRA }}=2 \mathrm{k} \Omega, \mathrm{R}_{\mathrm{L}}=450 \Omega, \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ |
|  |  |  |  |  | Rising/Falling Edge, $\mathrm{t}_{\mathrm{R}}, \mathrm{t}_{\mathrm{F}}$ |
| Output Slew Rate |  |  |  |  | Fig 1, Fig 2. $\mathrm{R}_{\text {SRA }}=10 \mathrm{k} \Omega, \mathrm{R}_{\mathrm{L}}=450 \Omega, \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ |
|  | 1.33 | 2.0 | 3 | V/ $/ \mathrm{s}$ | Rising/Falling Edge, $\mathrm{t}_{\mathrm{R}}, \mathrm{t}_{\mathrm{F}}$ |
| Output to Hi-Z Propagation Delay (Disable) |  |  |  |  | Fig 1, Fig 3. $\mathrm{R}_{\text {SRA }}=10 \mathrm{k} \Omega, \mathrm{R}_{\mathrm{L}}=450 \Omega, \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ |
|  |  | 0.3 | 1.0 | $\mu \mathrm{s}$ | $\mathrm{t}_{\mathrm{Hz}}$ |
|  |  | 0.5 | 1.0 | $\mu \mathrm{s}$ | $\mathrm{t}_{\mathrm{Lz}}$ |
| Hi-Z to Valid Output Propagation Delay (Enable) |  |  |  |  | Fig 1, Fig 3. $\mathrm{R}_{\text {SRA }}=10 \mathrm{k} \Omega, \mathrm{R}_{\mathrm{L}}=450 \Omega, \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ |
|  |  | 6.0 | 15 | $\mu \mathrm{s}$ | $\mathrm{t}_{\mathrm{zH}}$ |
|  |  | 7.0 | 15 | $\mu \mathrm{s}$ | $\mathrm{t}_{\mathrm{zL}}$ |

[^234]
## ABSOLUTE MAXIMUM RATINGS*

( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise noted)

|  |
| :---: |
|  |  |


| Input Voltages |  |
| :---: | :---: |
| $\mathrm{V}_{\text {IN }}$ | -0.3 to ( $\left.\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\right)$ |
| Ouput Voltages |  |
| $\mathrm{V}_{\text {Out }}$ | . -12 V to +12 V |
| Output Short Circuit Duration | Continuous |
| Power Dissipation Plastic DIP | 1250 mW |
| $\theta_{\text {IA }}$, Thermal Impedance | $75^{\circ} \mathrm{C} / \mathrm{W}$ |

Power Dissipation PLCC ............................. . . . 1000 mW
(Derate at $10 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+50^{\circ} \mathrm{C}$ ) $\theta_{\mathrm{JA}}$, Thermal Impedance . . . . . . . . . . . . . . . . . . . . . . . . . $80^{\circ} \mathrm{C} / \mathrm{W}$
Operating Temperature Range
Commercial (J Version) . . . . . . . . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Industrial (A Version) . . . . . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Lead Temperature (Soldering 10 sec ) .................. . $+300^{\circ} \mathrm{C}$
Vapour Phase ( 60 sec ) . . . . . . . . . . . . . . . . . . . . . . . . . . $+215^{\circ} \mathrm{C}$
Infrared (15 sec) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $+220^{\circ} \mathrm{C}$
*This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

ORDERING GUIDE

| Model | Temperature Range | Package Option* |
| :--- | :--- | :--- |
| ADM5170JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{N}-28$ |
| ADM5170AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-28$ |
| ADM5170JP | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{P}-28 \mathrm{~A}$ |
| ADM5170AP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | P-28A |

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the ADM5170 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


Figure 1. Timing Test Circuit


Figure 2. Rise/Fall Timing Waveforms


NC = NO CONNECT

PIN FUNCTION DESCRIPTION

| Mnemonic | Function |
| :---: | :---: |
| $V_{\text {DD }}$ | Power Supply Input, $+10 \mathrm{~V} \pm 10 \%$. |
| $\mathrm{V}_{\text {ss }}$ | Power Supply Input, $-10 \mathrm{~V} \pm 10 \%$. |
| GND | Ground Pin. Must be connected to 0 V . |
| $\mathrm{A}_{\mathrm{I}} \ldots . \mathrm{H}_{\mathrm{I}}$ | Digital Input to Drivers A to H. |
| $\mathrm{A}_{\mathrm{o}} \ldots \mathrm{H}_{0}$ | RS-232/RS-423 Output from Drivers A to H. |
| $\overline{\text { EN }}$ | Enable Pin. When high, all outputs are 3-stated. |
| MS+, MS- | Mode Select Inputs. Used to control the output level swing. With MS $+\&$ MS- connected to GND, RS-423A output levels are selected. With MS+ connected to $\mathrm{V}_{\mathrm{DD}}$ and MS- connected to $\mathrm{V}_{\mathrm{SS}}$, RS-232 output levels are developed. |
| SRA | Slew Rate Adjust Input. An external resistor (2 $\mathrm{k} \Omega$ to $10 \mathrm{k} \Omega$ ) connected between this pin and GND is used to control the Output Slew Rate ( $10 \mathrm{~V} / \mu \mathrm{s}$ to $2.2 \mathrm{~V} / \mu \mathrm{s})$. |

## Slew Rate Programming

The slew rate for the ADM5170 is controlled by a single resistor connected between the SRA pin and GND. The slew rate is approximately.

$$
\text { Slew Rate }(V / \mu s)=20 / R_{S R A}(k \Omega)
$$

Resistors between $2 \mathrm{k} \Omega$ and $10 \mathrm{k} \Omega$ may be used providing a slew rate which may be varied from $10 \mathrm{~V} / \mu \mathrm{s}$ to $2.2 \mathrm{~V} / \mu \mathrm{s}$. Figure 5 in the Typical Performance Characteristics section shows how the slew rate varies with $\mathrm{R}_{\text {SRA }}$ while Figure 8 shows how the transition time ( $10 \%$ to $90 \%$ ) varies with $\mathrm{R}_{\text {sRA }}$. Waveshaping of the output allows the user to control the level of interference (near-end crosstalk) which may be coupled to adjacent circuits in an interconnection. The recommended output characteristics for cable length and data rate are given in the EIA RS-423A specifications.
Maximum Data Rate $(\mathrm{kB} / \mathrm{s})=300 / \mathrm{t}$ (for rates from $1 \mathrm{kB} / \mathrm{s}$ to $100 \mathrm{kB} / \mathrm{s}$ ).

$$
\text { Cable Length }(\text { feet })=100 X t(\text { Max Length }=4000 \mathrm{ft} .)
$$

where $t$ is the transition time (in $\mu \mathrm{s}$ ) for the output to swing from $10 \%$ to $90 \%$ of its steady state values. The absolute maximum data rate is $100 \mathrm{kB} / \mathrm{s}$ and the maximum cable length is limited to 4000 ft .

## Output Mode Programming

The ADM5170 has two programmable output modes which provide different output voltage levels. The low output mode meets the specifications of EIA standards RS-423A while the high output mode meets the RS-232 specifications. The high output mode provides greater output swings and is suitable for driving lines where higher attenuation levels must be tolerated. This mode is selected by connecting the mode select pins to the supplies, MS+ to $\mathrm{V}_{\mathrm{DD}}$ and MS- to $\mathrm{V}_{\mathrm{SS}}$. The low output mode is selected by connecting both mode select pins MS+ and MS- to GND. This mode provides a controlled output swing with lower output levels.

| Inputs |  |  |  | Outputs |
| :--- | :--- | :--- | :--- | :--- |
| MS+ | MS- | $\overline{\text { EN }}$ | Data | Output |
| GND | GND | 0 | 0 | 5 V to $6 \mathrm{~V}(\mathrm{RS}-423)$ |
| GND | GND | 0 | 1 | -5 V to $-6 \mathrm{~V}(\mathrm{RS}-423)$ |
| $\mathrm{V}_{\text {DD }}$ | $\mathrm{V}_{\text {Ss }}$ | 0 | 0 | $\left(\mathrm{~V}_{\text {DD }}-3 \mathrm{~V}\right)(\mathrm{RS}-232)^{1}$ |
| $\mathrm{~V}_{\text {DD }}$ | $\mathrm{V}_{\text {Ss }}$ | 0 | 1 | $\left(\mathrm{~V}_{\text {ss }}+3 \mathrm{~V}\right)(\mathrm{RS}-232)^{1}$ |
| X | X | 1 | X | High Z |

${ }^{1}$ Minimum Output Level.

## Typical Application Circuit

A typical application circuit using a single driver in the ADM5170 is shown in Figure 4. This circuit is suitable for either RS-232 or RS-423 communication. An ADM5180 octal receiver is used to translate the signal back to CMOS logic level at the receiving end.


Figure 4. RS-232/RS-423A Typical Application Circuit

## FEATURES

Eight Differential Line Receivers in One Package
Meets EIA Standard EIA-232E, 423A, 422A and CCITT V.10, V.11, V. 28

## Single +5V Supply

Differential Inputs Withstand $\pm 25$ V
Internal Hysteresis
Low Power CMOS -3.5 mA Supply Current
TTL/CMOS Compatible Outputs
Available in 28-Pin DIP and PLCC Packages Low Power Replacement for UC5180C/NE5180

## APPLICATIONS

High Speed Communication
Computer I-O Ports
Peripherals
High Speed Modems

## Printers

Logic Level Translation

## GENERAL DESCRIPTION

The ADM5180 is an octal differential line receiver suitable for a wide range of digital communication systems with data rates up to $200 \mathrm{kB} / \mathrm{s}$. Input signals conforming to EIA Standards $232-\mathrm{E}, 422 \mathrm{~A}$ and CCITT V.10, V.11, V.28, X.26, and X. 27 are accepted and translated into TTL /CMOS output signal levels.

The ADM5180 is a superior upgrade for the UC5180C and the NE5180. It is fabricated on an advanced BiCMOS process, allowing high speed bipolar circuitry to be combined with low power CMOS. This minimizes the power consumption to less than 25 mW .

A failsafe function ensures a known output state under a variety of input fault conditions as defined in RS-422A and RS-423A. The failsafe function is controlled by FS1 and FS2. Each controls four receivers. With FS = Low and a fault condition the output is forced low while if FS = High, the output is forced high.

The device is available in both 28 -pin DIP and 28-lead PLCC packages.

FUNCTIONAL BLOCK DIAGRAM


Truth Table

| Differential Input <br> $(+)-(-)$ | Failsafe Input <br> FS1, FS2 | Receiver <br> Logic Output |
| :--- | :--- | :--- |
| $>200 \mathrm{mV}$ | X | H |
| $<-200 \mathrm{mV}$ | X | L |
| O/C | L | L |
| S/C | L | L |
| O/C | H | H |
| S/C | H | H |


| Parameter | Min | Typ | Max | Units |
| :--- | :--- | :--- | :--- | :--- | Test Conditions/Comments

note
${ }^{1}$ Only one output may be shorted at any time.
Specifications subject to change without notice.

## TIMING CHARACTERISTICS $\left(V_{00}=+5 \mathrm{~V} \pm 5 \%\right.$. All Specifications $\mathrm{T}_{\mathrm{mp}}$ to $\mathrm{T}_{\text {mx }}$ unless otherwise noted $)$

| Parameter | Min | Typ | Max | Units | Test Conditions/Comments |
| :--- | :--- | :--- | :--- | :--- | :--- |
| Propagation Delay-Low to High |  |  | 550 | ns | $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \mathrm{V}_{\mathrm{IN}}= \pm 500 \mathrm{mV}$ |
| Propagation Delay-High to Low |  |  | 550 | ns | $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \mathrm{V}_{\mathrm{IN}}= \pm 500 \mathrm{mV}$ |
| Acceptable Input Frequency |  | 0.1 | MHz | Unused Input Grounded, $\mathrm{V}_{\mathrm{IN}}= \pm 200 \mathrm{mV}$ |  |
| Rejectable Input Frequency | 5.5 |  | MHz | Unused Input Grounded, $\mathrm{V}_{\mathrm{IN}}= \pm 500 \mathrm{~mW}$ |  |

[^235]| ABSOLUTE MAXIMUM RATINGS ${ }^{1}$ <br> ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise noted) |  |
| :---: | :---: |
| $V_{\text {D }}$ | +7 V |
| Common-Mode Input Voltage | +15 V |
| Differential Input Voltage | +25 V |
| Failsafe Voltage | -0.3 V to $\mathrm{V}_{\mathrm{cc}}$ |
| Output Short Circuit Duration | Continuous ${ }^{2}$ |
| Power Dissipation Plastic DIP . . . . . . . . <br> (Derate at $12.5 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ Above $+50^{\circ} \mathrm{C}$ ) | 1250 mW |
| $\theta_{\mathrm{JA}}$, Thermal Impedance | $75^{\circ} \mathrm{C} / \mathrm{W}$ |
| Power Dissipation PLCC | 1000 mW |
| (Derate at $12.5 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ Above $+50^{\circ} \mathrm{C}$ ) |  |
| $\theta_{J A}$, Thermal Impedance | $+80^{\circ} \mathrm{C} / \mathrm{W}$ |


| Operating Temperature Range |  |
| :---: | :---: |
| Commercial ( J Version) | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ |
| Industrial (A Version) | $-40^{\circ} \mathrm{C}$ to $+80^{\circ} \mathrm{C}$ |
| Lead Temperature (Soldering 10 sec ) | $+300^{\circ} \mathrm{C}$ |
| Vapour Phase (60 sec) | $+215^{\circ} \mathrm{C}$ |
| Infrared (15 sec) | $+220^{\circ} \mathrm{C}$ |

## NOTES

${ }^{1}$ This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.
${ }^{2}$ Only one output should be shorted at any time.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the ADM5180 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



Figure 1. $V_{T L^{\prime}}, V_{T H^{\prime}}, V_{H}$ Definition


Figure 2. Timing Test Load


Figure 3. Timing Waveform

## ORDERING GUIDE

| Model | Temperature Range | Package Option ${ }^{\star}$ |
| :--- | :--- | :--- |
| ADM5180JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{N}-28$ |
| ADM5180AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-28$ |
| ADM5180JP | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | P-28A |
| ADM5180AP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | P-28A |

*For outline information see Package Information section.


## PLCC

ADM5180 23 G+
TOP VIEW FS2

$$
c_{0} 10
$$

$$
F_{0}
$$

D- 11


## PIN DESCRIPTION

| Mnemonic | Function |
| :---: | :---: |
| $V_{\text {D }}$ | Power Supply Input, $5 \mathrm{~V} \pm 5 \%$. |
| GND | Ground Pin. Must be connected to 0 V . |
| A+ . . $\mathrm{H}+$ | Noninverting Input to Differential Receivers A to H . |
| A- . . $\mathrm{H}-$ | Inverting Input to Differential Receivers A to H . |
| $\mathrm{A}_{\mathrm{o}} \ldots \mathrm{H}_{\mathrm{o}}$ | Receiver Outputs A to H. <br> A through D and FS2 controls receivers E through H . |
| FS1, FS2 | Failsafe Control Inputs. FS1 controls receivers A through D and FS2 control Receiver E through H . |

## APPLICATIONS INFORMATION <br> FAILSAFE OPERATION

The ADM5180 provides a failsafe operating mode to guard against input fault conditions as defined in RS-422A and RS-423A standards. The fault conditions are (1) Driver in power-off condition, (2) Receiver not interconnected with Driver, (3) Opencircuited interconnecting cable, and (4) Short-circuited interconnecting cable. If any of these four fault conditions occurs at the inputs of a receiver, then the output of that receiver is driven to a known logic level. The failsafe level is programmed using the failsafe (FS) input. There are two failsafe inputs, FS1 and FS2 which each control four receivers. FSI controls receivers A . . . D and FS2 controls receivers E...H. A connection to $V_{D D}$ on the failsafe input sets the output high under fault conditions while a connection to GND sets the output low.

| FS1, FS2 | Output During Fault Condition |
| :--- | :--- |
| V $_{\text {DD }}$ | High |
| GND | Low |

## Input Filtering

The ADM5180 contains internal low pass filtering for additional noise rejection. Frequencies above the passband will be rejected. For the specified input ( 5.5 MHz at $\pm 500 \mathrm{mV}$ ) the input stage attenuates the signal such that the threshold levels are not reached and therefore no change of state occurs on the output. The filtering is a function of both amplitude and and frequency. As the signal amplitude decreases then the rejected frequency will decrease.

## Motion Control Products Contents

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## Selection Tree - Motion Control



## Selection Guides-Motion Control Products

## Digital-to-Synchro and Resolver Converters

| Model | Res Bits | Output <br> Format ${ }^{1}$ | Accuracy arc mins | Load <br> Driving <br> Capability | Reference <br> Frequency <br> Options <br> Hz | Reference <br> Input Volt <br> Options <br> V rms | Signal <br> Output Volt <br> Options <br> V rms | Transformer Output Isolations | Package Options ${ }^{2}$ | Temp Ranges ${ }^{3}$ | Page ${ }^{4}$ | Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DRC1745 | 14 | $\mathrm{R}^{5}$ | $\pm 1, \pm 2, \pm 3$ | $2.0 \mathrm{VA}^{6}$ | $\mathrm{dc} \rightarrow 2600$ | $0 \rightarrow 3.4$ | $0 \rightarrow 6.8$ | Use Ext. STM 1680 and STM 1683 Transformer | M | M | CI 3-107 | Digital-to-Resolver Converter with Int. 2 VA Power Amplifier. Optional Int. TransZorb $\dagger$ Protection. 2 Byte Latched Inputs |
| AD2S65 | 14 | R | $\pm 2, \pm 4^{7}$ | - | $\mathrm{dc} \rightarrow 2600$ | $0 \rightarrow 3.4$ | $0 \rightarrow 6.8$ | - | M | C, M | CI 3-35 | Digital-to-Resolver Converter. <br> Autonulling (AN) Option |
| DRC1746 | 16 | $\mathrm{R}^{5}$ | $\pm 1, \pm 2, \pm 3$ | $2.0 \mathrm{VA}^{6}$ | $\mathrm{dc} \rightarrow 2600$ | $0 \rightarrow 3.4$ | $0 \rightarrow 6.8$ | Use Ext. STM 1680 and STM 1683 Transformer | M | M | CI 3-107 | 16-Bit Version of DRC1745 |
| AD2S66 | 16 | R | $\pm 1, \pm 2, \pm 4^{7}$ | - | $\mathrm{dc} \rightarrow 2600$ | $0 \rightarrow 3.4$ | $0 \rightarrow 6.8$ | - | M | C, M | CI 3-35 | Digital-to-Resolver Converter. <br> Autonulling (AN) Option |

## Motor Control

| Model | Description | Package Options ${ }^{2}$ | Temp Range ${ }^{3}$ | Page ${ }^{4}$ | Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| AD2S100 | AC Vector Controller | P | I | 16-51 | Vector Coordinate Transformation, $15 \mathrm{arc} \mathrm{min}, 2 \mu \mathrm{~s}$ Settling Time |

## Synchro/Resolver Support Components

| Model | Description | Package Options ${ }^{2}$ | $\begin{aligned} & \text { Temp } \\ & \text { Ranges }^{3} \end{aligned}$ | Page ${ }^{4}$ | Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| AD2S99 | Programmable Sine Wave Oscillator | P | I | 16-48 | $2 \mathrm{kHz} \mathbf{- 2 0} \mathbf{k H z}$ Freq., Transducer Output Phase Locking |
| AD2S75 | Signal and Reference Isolation for AD2S80/81/82 | M | C, M | CI 3-43 | $56-20,000 \mathrm{~Hz}$ Freq, 11.8-115 V rms Ref, 11.8/26/90 V rms Input |
| OSC1758 | Hybrid Sine/Cosine Power Oscillator | M | C, M | CI 3-117 | $0.0-10 \mathrm{kHz}$ Frequency Range ${ }^{6}$, In-phase and Quadrature Outputs, 1.5 W Output Power |

## LVDT Signal Conditioners

| Model | Description | Package $^{\text {Options }}{ }^{\mathbf{2}}$ | Temp Ranges ${ }^{\mathbf{3}}$ | Page $^{4}$ | Comments |
| :--- | :--- | :--- | :--- | :--- | :--- |
| AD598 | Single Chip LVDT Driver/Amplifier | D, R | C, I | 16-63 | 20 Hz-20 kHz, Phase Insensitive, High Accuracy |
| AD698 | Single Chip 4-Wire LVDT Driver/Amplifier | P, Q | I, M | $\mathbf{1 6 - 6 7}$ | Improved Performance, Multiple Configurations |

${ }^{1} \mathrm{~S}=$ Synchro; $\mathrm{R}=$ Resolver.
${ }^{2}$ Package Options: D = Hermetic DIP, Ceramic or Metal; E = Ceramic Leadless Chip Carrier; F = Ceramic Flatpack; G = Ceramic Pin Grid Array; H = Hermetic Metal Can; J = J-Leaded Ceramic Package;
 ST = Thin Quad Flatpack; T = TO-92; U = TSOP-Thin Small Outline Package; $\mathrm{W}=$ Nonhermetic Ceramic/Glass DIP; $Y=$ Single-In-Line "SIP" Package; $Z=$ Ceramic Leaded Chip Carrier
 ignator will be followed by: / to indicate 883B, for JAN, ${ }_{\text {D }}$ for SMD, and for space level.
${ }^{4} \mathrm{CI}=$ Data Converter Reference Manual, Volume $I$. All other entries refer to this volume
${ }^{5}$ Sy = Data Converter Reference Manual, Volume I. An other entries
5 Synchro format output with external output transformer STM1683:
${ }^{6}$ Can be used with pulsating power supply for reduced dissipation.
${ }^{7}$ Can be used with pu
Boldface Type: Data sheet information in this volume.
$\dagger$ TransZorb is a trademark of General Semiconductor Industries, Inc.

## Selection Guides-Motion Control Products

Synchro, Resolver, Inductosyn $\dagger$ and LVDT-to-Digital Converters

| Model | Res Bits | Input <br> Format ${ }^{1}$ | Accuracy arc mins | Tracking Rate Options revs/sec ${ }^{2}$ | Reference <br> Frequency <br> Options Hz | Input <br> Isol | Package Options ${ }^{3}$ | Temp Ranges ${ }^{4}$ | Page ${ }^{5}$ | Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SDC/RDC1741 | 12 | S, R | $\pm 15.3$ | 18 | 400, 2.6 k | Yes | M | C, M | CI 3-119 | Tristate, Latched Output Internal Transformer Isolation |
| SDC/RDC1742 | 12 | S, R | $\pm 8.5$ | 18 | 400, 2.6 k | Yes | M | C, M | CI 3-119 | Tristate, Latched Output Internal Transformer Isolation |
| AD2S81A ${ }^{6}$ | 12 | I, R | $\pm 30^{7}$ | 260 | $\mathbf{4 0 0} \rightarrow 20 \mathrm{k}$ | No | D | C | 16-11 | Monolithic, User Selectable Dynamic Characteristics, High Tracking Rate, Quality Velocity Output, Class 2 ESD |
| SDC/RDC1740 | 14 | S, R | $\pm 5.3$ | 27 | 400, 2.6 k | Yes | M | C, M | CI 3-119 | Tristate, Latched Output Internal Transformer Isolation |
| AD2S80A ${ }^{6}$ | $\begin{aligned} & 16,14, \\ & 12,10^{8} \end{aligned}$ | I, R | $\pm 2, \pm 4, \pm 8$ | $1040{ }^{9}$ | 50-20 k | No | D, E | $\mathbf{C , I}, \mathbf{M} / \mathbf{D}$ | 16-7 | Monolithic, User Selectable Dynamic Characteristics and Resolution. High Tracking Rate and Quality Velocity Output |
| AD2S82A ${ }^{6}$ | $\begin{aligned} & 16,14, \\ & 12,10^{8} \end{aligned}$ | I, R | $\pm 2, \pm 4, \pm 8$ | $1040^{9}$ | 50-20 k | No | P | C | 16-11 | Monolithic, User Selectable Dynamic Characteristics and Resolution. High Tracking Rate and Quality Velocity Output |
| AD2S83 | $\begin{aligned} & 16,14, \\ & 12,10^{8} \end{aligned}$ | I, R | $\pm 8$ | $1040^{9}$ | 50-20 k | No | P | I | 16-15 | Monolithic, User Selectable <br> Dynamic Characteristics and Resolution. High Tracking Rate and $\pm 0.15 \%$ Linearity Velocity Output |
| AD2S34 | 14 | R | $\pm 2.6, \pm 4.0$ | 20, 48 | 0.4, 2.6, 4.0 k | No | Z | M | CI 3-7 | Dual Channel Resolver-to-Digital Converter with On-Board Oscillator |
| AD2S46 | 16 | S, R | $\pm 1.3, \pm 2.6$ | 12 | $0.4 \rightarrow 2.6 \mathrm{k}$ | No | D | M | CI 3-23 | 16-Bit Resolver/Synchro-toDigital Converter, 1.3 arc min |


| Model | Res Bits | Input <br> Format ${ }^{1}$ | Accuracy arc mins | Tracking Rate Options revs/sec ${ }^{2}$ | Reference <br> Frequency <br> Options Hz | Input <br> Isol | Package Options ${ }^{3}$ | Temp <br> Ranges ${ }^{4}$ | Page ${ }^{5}$ | Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| AD2S44 | 14 | S, R | $\begin{aligned} & \pm 2.6,{ }^{10} \pm 4.0, \\ & \pm 5.2 \end{aligned}$ | 20 | $0.4 \rightarrow 2.6 \mathrm{k}$ | No | M | M | CI 3-15 | Dual Channel Resolver/ Synchro-to-Digital Converter with Loss of Track Detection |
| AD2S90 | 12 | I, R | $\pm 8$ | 375 | $2.0 \rightarrow 10.0 \mathrm{k}$ | No | P | C, I | 16-27 | Low Cost RDC, Incremental Encoder and Absolute Position Output |
| AD2S93 | 14 | LVDT | 0.1, 0.05\% | TBD | $2.0-10.0 \mathrm{k}$ | No | P | I | 16-37 | 14-Bit LVDT-to-Digital Converter |

${ }^{1} \mathrm{~S}=$ Synchro; $\mathbf{R}=$ Resolver; $\mathrm{I}=$ Inductosyn.
${ }^{2}$ In general, higher reference frequency options have higher tracking rates.

 Quad Flatpack; ST $=$ Thin Quad Flatpack; $T=$ TO-92; $U=$ TSOP - Thin Small Outline Package; $W=$ Nonhermetic Ceramic/Glass DIP; $Y=$ Single-In-Line "SIP" Package; $Z=$ Ceramic Leaded Chip Carrier.
 temperature designator will be followed by: / to indicate 883 B , for JAN, ${ }_{\mathrm{D}}$ for SMD, and ${ }_{\mathrm{S}}$ for space level.
${ }^{5} \mathrm{CI}=$ Data Converter Reference Manual, Volume I. All other entries refer to this volume.
${ }^{6}$ Die Revision.
${ }^{7}$ Consult data sheet.
${ }^{8}$ Resolution is user selectable.
${ }^{9}$ Depends on resolution selected.
${ }^{10} \pm 2.6$ arc min only available over $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$.
Boldface Type: Data sheet information in this volume.
$\dagger$ Inductosyn is a registered trademark of Farrand Industries, Inc.

FEATURES<br>Monolithic (BiMOS II) Tracking R/D Converter 40-Pin DIP Package<br>44-Pin LCC Package<br>10-, 12-, 14- and 16-Bit Resolution Set by User Ratiometric Conversion<br>Low Power Consumption: $\mathbf{3 0 0} \mathbf{~ m W}$ typ<br>Dynamic Performance Set by User<br>High Max Tracking Rate 1040 RPS (10 Bits) Velocity Output<br>Industrial Temperature Range Versions Military Temperature Range Versions<br>ESD Class 2 Protection ( $2,000 \mathrm{~V}$ min)<br>/883 B Parts Available

## APPLICATIONS

DC Brushless and AC Motor Control Process Control Numerical Control of Machine Tools Robotics<br>Axis Control<br>Military Servo Control

## GENERAL DESCRIPTION

The AD2S80A is a monolithic 10 -, 12 -, 14 - or 16 -bit tracking resolver-to-digital converter contained in a 40 -pin DIP or 44-pin LCC ceramic package. It is manufactured on a BiMOS II process that combines the advantages of CMOS logic and bipolar high accuracy linear circuits on the same chip.
The converter allows users to select their own resolution and dynamic performance with external components. This allows the users great flexibility in defining the converter that best suits their system requirements. The converter allows users to select the resolution to be $10,12,14$ or 16 bits and to track resolver signals rotating at up to 1040 revs per second ( $62,400 \mathrm{rpm}$ ) when set to 10 -bit resolution.
The AD2S80A converts resolver format input signals into a parallel natural binary digital word using a ratiometric tracking conversion method. This ensures high-noise immunity and tolerance of lead length when the converter is remote from the resolver.
The $10-, 12-, 14$ - or 16 -bit output word is in a three-state digital logic available in 2 bytes on the 16 output data lines. BYTE SELECT, ENABLE and INHIBIT pins ensure easy data transfer to 8 - and 16 -bit data buses, and outputs are provided to allow for cycle or pitch counting in external counters.

An analog signal proportional to velocity is also available and can be used to replace a tachogenerator.

The AD2S80A operates over 50 Hz to $20,000 \mathrm{~Hz}$ reference frequency.

FUNCTIONAL BLOCK DIAGRAM


## PRODUCT HIGHLIGHTS

Monolithic. A one chip solution reduces the package size required and increases the reliability.
Resolution Set by User. Two control pins are used to select the resolution of the AD 2 S 80 A to be $10,12,14$ or 16 bits allowing the user to use the AD2S80A with the optimum resolution for each application.

Ratiometric Tracking Conversion. Conversion technique provides continuous output position data without conversion delay and is insensitive to absolute signal levels. It also provides good noise immunity and tolerance to harmonic distortion on the reference and input signals.
Dynamic Performance Set by the User. By selecting external resistor and capacitor values the user can determine bandwidth, maximum tracking rate and velocity scaling of the converter to match the system requirements. The external components required are all low cost preferred value resistors and capacitors, and the component values are easy to select using the simple instructions given.
Velocity Output. An analog signal proportional to velocity is available and is linear to typically one percent. This can be used in place of a velocity transducer in many applications to provide loop stabilization in servo controls and velocity feedback data.

Low Power Consumption. Typically only 300 mW .
Military Product. The AD2S80A is available processed in accordance with MIL-STD-883B, Class B.

MODELS AVAILABLE
Information on the models available is given in the section "Ordering Guide."

## AD2S8OA - SPEGIFIGATIONS (typical at $+25^{\circ} \mathrm{C}$ unless otherwise noted)

| Parameter |  | Min AD2S80A |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | Conditions |  |  |  |  |
| SIGNAL INPUTS |  |  |  |  |  |
| Frequency |  | 50 |  | 20,000 |  |
| Voltage Level |  | 1.8 | 2.0 | 2.2 | $\mathrm{V} \text { rms }$ |
| Input Bias Current |  |  | 60 | 150 | nA |
| Input Impedance |  | 1.0 |  |  | $\mathrm{M} \Omega$ |
| Maximum Voltage |  |  |  | 8 | V pk |
| REFERENCE INPUT |  |  |  |  | Hz <br> V pk <br> nA <br> $\mathrm{M} \Omega$ |
| Frequency |  | 50 |  | 20,000 |  |
| Voltage Level |  | 1.0 |  | 8.0 |  |
| Input Bias Current |  |  | 60 | 150 |  |
| Input Impedance |  | 1.0 |  |  |  |
| CONTROL DYNAMICS |  |  |  |  | LSB <br> Degrees <br> rps <br> rps <br> rps <br> rps |
| Repeatability |  |  |  | 1 |  |
| Allowable Phase Shift | (Signals to Reference) | $-10$ |  | +10 |  |
| Tracking Rate | 10 Bits |  |  | 1040 |  |
|  | 12 Bits |  |  | 260 |  |
|  | 14 Bits |  |  | 65 |  |
| Bandwidth ${ }^{1}$ | 16 Bits |  |  | 16.25 |  |
|  | User Selectable |  |  |  |  |
| ACCURACY |  |  |  |  | arc min arc min arc min |
| Angular Accuracy | A, J, S |  |  | $\pm 8+1$ LSB |  |
| Monotonicity <br> Missing Codes (16-Bit Resolution) | B, K, T |  |  | $\pm 4+1$ LSB |  |
|  | L, U |  |  | $\pm 2+1$ LSB |  |
|  | Guaranteed Monotonic |  |  |  |  |
|  | A, B, J, K, S, T |  |  | 4 | Codes Code |
|  | L, U |  |  | 1 |  |
| VELOCITY SIGNAL |  |  |  |  | \% FSD |
| Linearity | Over Full Range |  | $\pm 1$ | $\pm 3$ |  |
| Reversion Error |  |  | $\pm 1$ | $\pm 2$ | \% FSD |
| DC Zero Offset ${ }^{2}$ |  |  |  | 6 |  |
| DC Zero Offset Tempco |  |  | -22 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Gain Scaling Accuracy |  |  |  | $\pm 10$ | \% FSD |
| Output Voltage | 1 mA Load | $\pm 8$ | $\pm 9$ | $\pm 10.5$ |  |
| Dynamic Ripple | Mean Value |  |  | 1.5 | \% rms O/P |
| Output Load |  |  |  | 1.0 |  |
| INPUT/OUTPUT PROTECTION | Overvoltage Protection Short Circuit O/P Protection | $\pm 5.6$ | $\begin{aligned} & \pm 8 \\ & \pm 8 \end{aligned}$ | $\pm 10.4$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~mA} \end{aligned}$ |
| Analog Inputs |  |  |  |  |  |
| Analog Outputs |  |  |  |  |  |
| DIGITAL POSITION | $10,12,14$, and 16 <br> Bidirectional Natural Binary |  | 3 |  | LSTTL |
| Resolution |  |  |  |  |  |  |
| Output FormatLoad |  |  |  |  |  |  |
|  |  |  |  |  |  |  |
| $\overline{\text { INHIBIT }}^{3}$ | Logic LO to Inhibit |  | 600 |  | ns |
| Sense |  |  |  |  |  |  |
| Time to Stable Data |  |  |  |  |  |  |
| $\overline{\overline{\text { ENABLE }}^{3}}{ }^{\text {ENABLE }}$ Time | Logic LO Enables Position Output. Logic HI Outputs in High Impedance State | 35 |  | 110 | ns |
|  |  |  |  |  |  |
| BYTE SELECT ${ }^{3}$ | MS Byte DB1-DB8, LS Byte DB9-DB16 LS Byte DB1-DB8, LS Byte DB9-DB16 | 60 |  | 140 | ns |
| Sense |  |  |  |  |  |
| Logic HI |  |  |  |  |  |
| Logic LO |  |  |  |  |  |
| Time to Data Available |  |  |  |  |  |
| SHORT CYCLE INPUTS | Internally Pulled High ( $100 \mathrm{k} \Omega$ to $+\mathrm{V}_{\mathrm{S}}$ ) |  |  |  |  |
| SC1 SC2 |  |  |  |  |  |
| 00 | 10 Bit |  |  |  |  |
| 01 | 12 Bit |  |  |  |  |
| 10 | 14 Bit |  |  |  |  |
| 11 | 16 Bit |  |  |  |  |
| $\begin{aligned} & \text { DATA LOAD } \\ & \text { Sense } \end{aligned}$ | Internally Pulled High ( $100 \mathrm{k} \Omega$ ) to $+\mathrm{V}_{\mathrm{s}}$. Logic LO Allows Data to be Loaded into the Counters from the Data Lines |  | 150 | 300 | ns |
|  |  |  |  |  |  |
| BUSY ${ }^{3}$ | Logic HI When Position O/P Changing | 200 |  | 600 | $\begin{aligned} & \text { ns } \\ & \text { LSTTL } \end{aligned}$ |
| Sense |  |  |  |  |  |
| Width |  |  |  |  |  |
| Load | Use Additional Pull-Up |  |  |  |  |


| Parameter | Conditions | Min | $\begin{gathered} \text { AD2S8 } \\ \text { Typ } \\ \hline \end{gathered}$ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DIRECTION ${ }^{3}$ <br> Sense <br> Max Load | Logic HI Counting Up Logic LO Counting Down |  |  | 3 | LSTTL |
| RIPPLE CLOCK ${ }^{3}$ <br> Sense <br> Width <br> Reset <br> Load | Logic HI; All 1s to All 0s; All 0s to all 1s Dependent on Input Velocity Before Next Busy | 300 |  | 3 | LSTTL |
| DIGITAL INPUTS High Voltage, $\mathrm{V}_{\mathrm{IH}}$ Low Voltage, $\mathrm{V}_{\mathrm{IL}}$ | INHIBIT, ENABLE <br> DB1-DB16, Byte Select $\pm \mathrm{V}_{\mathrm{S}}= \pm 10.8 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=5.0 \mathrm{~V}$ <br> INHIBIT, ENABLE <br> DB1-DB16, Byte Select $\pm \mathrm{V}_{\mathrm{S}}= \pm 13.2 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=5.0 \mathrm{~V}$ | 2.0 |  | 0.8 | V V |
| DIGITAL INPUTS <br> High Current, $\mathrm{I}_{\mathrm{IH}}$ <br> Low Current, $\mathrm{I}_{\mathrm{IL}}$ | $\overline{\text { INHIBIT }}, \overline{\text { ENABLE }}$ <br> DB1-DB16 $\pm \mathrm{V}_{\mathrm{S}}= \pm 13.2 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=5.5 \mathrm{~V}$ <br> INHIBIT, ENABLE <br> DB1-DB16, Byte Select $\pm \mathrm{V}_{\mathrm{S}}= \pm 13.2 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=5.5 \mathrm{~V}$ |  |  | $\begin{aligned} & \pm 100 \\ & \pm 100 \end{aligned}$ | $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ |
| DIGITAL INPUTS Low Voltage, $\mathrm{V}_{\mathrm{IL}}$ <br> Low Current, $\mathrm{I}_{\mathrm{IL}}$ | $\overline{\text { ENABLE }}=\mathrm{HI}$ <br> SC1, SC2, Data Load $\begin{aligned} & \pm \mathrm{V}_{\mathrm{S}}= \pm 12.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=5.0 \mathrm{~V} \\ & \text { ENABLE }=\mathrm{HI} \\ & \text { SC1, SC } 2, \text { Data Load } \\ & \pm \mathrm{V}_{\mathrm{S}}= \pm 12.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=5.0 \mathrm{~V} \end{aligned}$ |  |  | $1.0$ $-400$ | V $\mu \mathrm{A}$ |
| DIGITAL OUTPUTS High Voltage, $\mathrm{V}_{\mathrm{OH}}$ Low Voltage, $\mathrm{V}_{\mathrm{OL}}$ | DB1-DB16 <br> RIPPLE CLK, DIR $\begin{aligned} & \pm \mathrm{V}_{\mathrm{S}}= \pm 12.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=4.5 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{OH}}=100 \mu \mathrm{~A} \\ & \mathrm{DB} 1-\mathrm{DB} 16 \\ & \mathrm{RIPPLE} \text { CLK, DIR } \\ & \pm \mathrm{V}_{\mathrm{S}}= \pm 12.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=5.5 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{OL}}=1.2 \mathrm{~mA} \end{aligned}$ | 2.4 |  | 0.4 | V |
| THREE STATE LEAKAGE Current $\mathrm{I}_{\mathrm{L}}$ | $\begin{aligned} & \text { DB1-DB16 Only } \\ & \pm \mathrm{V}_{\mathrm{S}}= \pm 12.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=5.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{OL}}=0 \mathrm{~V} \\ & \pm \mathrm{V}_{\mathrm{S}}= \pm 12.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=5.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{OH}}=5.0 \mathrm{~V} \end{aligned}$ |  |  | $\begin{aligned} & \pm 100 \\ & \pm 100 \\ & \hline \end{aligned}$ | $\begin{aligned} & \mu \mathrm{A} \\ & \mu \mathrm{~A} \end{aligned}$ |
| POWER SUPPLIES <br> Voltage Levels $+\mathrm{V}_{\mathrm{s}}$ <br> $-\mathrm{V}_{\mathrm{S}}$ $+V_{L}$ <br> Current <br> $\pm \mathrm{I}_{\mathrm{S}}$ <br> $\pm \mathrm{I}_{\mathrm{S}}$ <br> $\pm \mathrm{I}_{\mathrm{L}}$ | $\begin{aligned} & \pm \mathrm{V}_{\mathrm{S}} @ \pm 12 \mathrm{~V} \\ & \pm \mathrm{V}_{\mathrm{s}} @ \pm 13.2 \mathrm{~V} \\ & +\mathrm{V}_{\mathrm{L}} @ \pm 5.0 \mathrm{~V} \\ & \hline \end{aligned}$ | $\begin{aligned} & +10.8 \\ & -10.8 \\ & +5 \end{aligned}$ | $\begin{aligned} & \pm 12 \\ & \pm 19 \\ & \pm 0.5 \end{aligned}$ | $\begin{aligned} & +13.2 \\ & -13.2 \\ & +13.2 \\ & \\ & \pm 23 \\ & \pm 30 \\ & \pm 1.5 \end{aligned}$ | V <br> V <br> V <br> mA <br> mA <br> mA |

NOTES
${ }^{1}$ Refers to small signal bandwidth.
${ }^{2}$ Output offset dependent on value for R6.
${ }^{3}$ Refer to timing diagram.
Specifications subject to change without notice.
All min and max specifications are guaranteed. Specifications in boldface are tested on all production units at final electrical test.

## ESD SENSITIVITY

The AD2S80A features an input protection circuit consisting of large "distributed" diodes and polysilicon series resistors to dissipate both high energy discharges (Human Body Model) and fast, low energy pulses (Charges Device Model).
The AD2S80A is ESD protection Class II ( 2000 V min). Proper ESD precautions are strongly recommended to avoid functional damage or performance degradation. For further information on
 ESD precautions, refer to Analog Devices ESD Prevention Manual.

## AD2S80A

## RECOMMENDED OPERATING CONDITIONS

Power Supply Voltage ( $+\mathrm{V}_{\mathrm{S}},-\mathrm{V}_{\mathrm{S}}$ ) . . . . . . $\pm 12 \mathrm{~V}$ dc $\pm 10 \%$
Power Supply Voltage $\mathrm{V}_{\mathrm{L}}$. . . . . . . . . . . . . . +5 V dc $\pm 10 \%$
Analog Input Voltage (SIN and COS) . . . . . . . $2 \mathrm{~V} \mathrm{rms} \pm 10 \%$
Analog Input Voltage (REF) . . . . . . . . . . . . 1 V to 8 V peak
Signal and Reference Harmonic Distortion . . . . . . . 10\% (max)
Phase Shift Between Signal and Reference . $\pm 10$ Degrees (max)
Ambient Operating Temperature Range
Commercial (JD, KD, LD) . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Industrial (AD, BD) . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Extended (SD, SE, TD, TE, UD, UE) . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
ABSOLUTE MAXIMUM RATINGS ${ }^{1}$ (with respect to GND)
$+V_{s}{ }^{2}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . +14 V dc
$-V_{\text {S }}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . -14 V dc
$+V_{L}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $+V_{S}$
Reference . . . . . . . . . . . . . . . . . . . . . . . . +14 V to $-\mathrm{V}_{\mathrm{S}}$
SIN . . . . . . . . . . . . . . . . . . . . . . . . . . . . . +14 V to $-V_{S}$
COS . . . . . . . . . . . . . . . . . . . . . . . . . . . . +14 V to $-\mathrm{V}_{\mathrm{S}}$
Any Logical Input . . . . . . . . . . . . . . . -0.4 V dc to $+\mathrm{V}_{\mathrm{L}}$ dc
Demodulator Input . . . . . . . . . . . . . . . . . . . +14 V to $-\mathrm{V}_{\mathrm{S}}$
Integrator Input . . . . . . . . . . . . . . . . . . . . . +14 V to $-\mathrm{V}_{\mathrm{S}}$
VCO Input . . . . . . . . . . . . . . . . . . . . . . . . +14 V to $-\mathrm{V}_{\mathrm{S}}$
Power Dissipation . . . . . . . . . . . . . . . . . . . . . . . . 860 mW
Operating Temperature
Commercial (JD, KD, LD) . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Industrial (AD, BD) . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Extended (SD, SE, TD, TE, UD, UE) . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
$\theta_{\mathrm{JC}}{ }^{3}$ (40-Pin DIP 883 Parts Only) . . . . . . . . . . . . . . $11^{\circ} \mathrm{C} / \mathrm{W}$
$\theta_{\mathrm{JC}}{ }^{3}$ (44-Pin LCC 883 Parts Only) . . . . . . . . . . . . . . $10^{\circ} \mathrm{C} / \mathrm{W}$
Storage Temperature (All Grades) . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 sec ) . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
CAUTION:

1. Absolute Maximum Ratings are those values beyond which damage to the device may occur.
2. Correct polarity voltages must be maintained on the $+\mathrm{V}_{\mathrm{s}}$ and $-\mathrm{V}_{\mathrm{s}}$ pins.
3. With reference to Appendix C of MIL-M-38510.

ORDERING GUIDE

| Model | Operating <br> Temperature Range | Accuracy | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD2S80AJD | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $8 \operatorname{arc}$ min | $\mathrm{D}-40$ |
| AD2S80AKD | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $4 \operatorname{arc}$ min | $\mathrm{D}-40$ |
| AD2S80ALD | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $2 \operatorname{arc}$ min | $\mathrm{D}-40$ |
| AD2S80AAD | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $8 \operatorname{arc}$ min | $\mathrm{D}-40$ |
| AD2S80ABD | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $4 \operatorname{arc}$ min | $\mathrm{D}-40$ |
| AD2S80ASD | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $8 \operatorname{arc}$ min | $\mathrm{D}-40$ |
| AD2S80ATD | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $4 \operatorname{arc}$ min | $\mathrm{D}-40$ |
| AD2S80AUD | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $2 \operatorname{arc}$ min | $\mathrm{D}-40$ |
| AD2S80ASE | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $8 \operatorname{arc}$ min | $\mathrm{E}-44 \mathrm{~A}$ |
| AD2S80ATE | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $4 \operatorname{arc}$ min | $\mathrm{E}-44 \mathrm{~A}$ |
| AD2S80AUE | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $2 \operatorname{arc}$ min | $\mathrm{E}-44 \mathrm{~A}$ |
| AD2S80ASD/883BB | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $8 \operatorname{arc}$ min | $\mathrm{D}-40$ |
| AD2S80ATD/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $4 \operatorname{arc}$ min | $\mathrm{D}-40$ |
| AD2S80ASE/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $8 \operatorname{arc}$ min | $\mathrm{E}-44 \mathrm{~A}$ |
| AD2S80ATE/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $4 \operatorname{arc}$ min | $\mathrm{E}-44 \mathrm{~A}$ |

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## AD2S80A PIN CONFIGURATIONS

DIP (D) Package


LCC (E) Package


PIN DESIGNATIONS

| MNEMONIC | DESCRIPTION |
| :---: | :---: |
| REFERENCE I/P | REFERENCE SIGNAL INPUT |
| DEMOD I/P | DEMODULATOR INPUT |
| AC ERROR O/P | RATIO MULTIPLIER OUTPUT |
| cos | COSINE INPUT |
| ANALOG GROUND | POWER GROUND |
| SIGNAL GROUND | RESOLVER SIGNAL GROUND |
| SIN | SINE INPUT |
| + $\mathrm{V}_{\text {s }}$ | POSITIVE POWER SUPPLY |
| DB1-DB16 | PARALLEL OUTPUT DATA |
| $\mathrm{V}_{\mathrm{L}}$ | LOGIC POWER SUPPLY |
| ENABLE | LOGIC HI-OUTPUT DATA IN HIGH IMPEDANCE STATE, LOGIC LO PRESENTS DATA TO THE OUTPUT LATCHES. |
| BYte SELECT | LOGIC HI-MOST SIGNIFICANT BYTE TO DB1-DB8 LOGIC LO-LEAST SIGNIFICANT BYTE TO DB1-DB8. |
| INHIBIT | LOGIC LO INHIBITS DATA TRANSFER TO OUTPUT LATCHES. |
| DIGITAL GROUND | DIGITAL GROUND |
| SC1-SC2 | SELECT CONVERTER RESOLUTION |
| DATA LOAD | LOGIC LO DB1-D16 INPUTS LOGIC HI DB1-D16 OUTPUTS |
| BUSY | CONVERTER BUSY, DATA NOT VALID WHILE BUSY HI |
| DIRECTION | LOGIC STATE DEFINES DIRECTION OF INPUT SIGNAL ROTATION |
| RIPPLE CLOCK | PÓSITIVE PULSE WHEN CONVERTER OUTPUT CHANGES FROM is TO ALL OS OR VICE VERSA |
| $-v_{s}$ | NEGATIVE POWER SUPPLY |
| VCO 1/P | VCO INPUT |
| INTEGRATOR I/P | INTEGRATOR INPUT |
| INTEGRATOR O/P | INTEGRATOR OUTPUT |
| DEMOD O/P | DEMODULATOR OUTPUT |

# Variable Resolution, Monolithic Resolver-to-Digital Converters AD2S81A/AD2S82A 

FEATURES
Monolithic (BiMOS II) Tracking R/D Converter
Ratiometric Conversion
Low Power Consumption: $\mathbf{3 0 0} \mathbf{m W}$ typ
Dynamic Performance Set by User
Velocity Output
ESD Class 2 Protection (2,000 V min)
AD2S81A
28-Pin DIP Package
Low Cost
AD2S82A
44-Pin PLCC Package
10-, 12-, 14- and 16-Bit Resolution Set by User
High Max Tracking Rate 1040 RPS ( 10 Bits)
VCO Output (Inter LSB Output)
Data Complement Facility
APPLICATIONS
DC Brushless and AC Motor Control
Process Control
Numerical Control of Machine Tools

## Robotics

Axis Control

## GENERAL DESCRIPTION

The AD2S82A is a monolithic 10 -, 12 -, 14 - or 16 -bit tracking resolver-to-digital converter contained in a 44-pin J leaded PLCC package. Two extra functions are provided in the new surface mount package - COMPLEMENT and VCO output.
The AD2S81A is a monolithic 12 -bit fixed resolution tracking resolver-to-digital converter packaged in a 28 -pin DIP.
The converters allow users to select their own dynamic performance with external components. This allows the users great flexibility in defining the converter that best suits their system requirements. The AD2S82A allows users to select the resolution to be 10,12 , 14 or 16 bits and to track resolver signals rotating at up to 1040 revs per second $(62,400 \mathrm{rpm})$ when set to 10 -bit resolution.
The AD2S81A and AD2S82A convert resolver format input signals into a parallel natural binary digital word using a ratiometric tracking conversion method. This ensures high-noise immunity and tolerance of lead length when the converter is remote from the resolver.
The output word is in a three-state digital logic form available in 2 bytes on the 16 output data lines for the AD2S82A and on 8 output data lines for the AD2S81A. BYTE SELECT, $\overline{\text { ENABLE }}$ and INHIBIT pins ensure easy data transfer to 8 - and 16 -bit data buses, and outputs are provided to allow for cycle or pitch counting in external counters.
An analog signal proportional to velocity is also available and can be used to replace a tachogenerator.

AD2S82A FUNCTIONAL BLOCK DIAGRAM


## PRODUCT HIGHLIGHTS

Monolithic. A one-chip solution reduces the package size required and increases the reliability.
Resolution Set by User. Two control pins are used to select the resolution of the AD 2 S 82 A to be $10,12,14$ or 16 bits allowing the user to use the AD2S82A with the optimum resolution for each application.
Ratiometric Tracking Conversion. Conversion technique provides continuous output position data without conversion delay and is insensitive to absolute signal levels. It also provides good noise immunity and tolerance to harmonic distortion on the reference and input signals.
Dynamic Performance Set by the User. By selecting external resistor and capacitor values the user can determine bandwidth, maximum tracking rate and velocity scaling of the converter to match the system requirements. The external components required are all low cost, preferred value resistors and capacitors, and the component values are easy to select using the simple instructions given.
Velocity Output. An analog signal proportional to velocity is available and is linear to typically one percent. This can be used in place of a velocity transducer in many applications to provide loop stabilization in servo controls and velocity feedback data.
Low Power Consumption. Typically only 300 mW .

## MODELS AVAILABLE

Information on the models available is given in the section "Ordering Information."

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## AD2S81 A/AD2S82A _ SPEGFGATIONS (typical at $+25^{\circ} \mathrm{C}$ unless otherwise noted)

| Parameter | Conditions | Min | $\begin{gathered} \text { D2S8] } \\ \text { Typ } \end{gathered}$ | Max | Min | $\begin{gathered} \text { D2S8 } \\ \text { Typ } \end{gathered}$ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SIGNAL INPUTS <br> Frequency <br> Voltage Level Input Bias Current Input Impedance Maximum Voltage | $\cdots$ | $\begin{aligned} & 400 \\ & 1.8 \\ & 1.0 \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 60 \end{aligned}$ | $\begin{aligned} & 20,000 \\ & 2.2 \\ & 150 \\ & \pm 8 \end{aligned}$ | 50 | $\star$ <br> $\star$ <br> $\star$ <br> $\star$ <br>  | $20,000$ | Hz <br> V rms <br> nA <br> $\mathrm{M} \Omega$ <br> V pk |
| REFERENCE INPUT <br> Frequency <br> Voltage Level Input Bias Current Input Impedance |  | $\begin{aligned} & 400 \\ & 1.0 \\ & 1.0 \end{aligned}$ | 60 | $\begin{aligned} & 20,000 \\ & 8.0 \\ & 150 \end{aligned}$ | 50 |  | $20,000$ | Hz <br> V pk <br> nA <br> $M \Omega$ |
| CONTROL DYNAMICS <br> Repeatability Allowable Phase Shift Tracking Rate $\text { Bandwidth }{ }^{1}$ | (Signals to Reference) <br> 10 Bits <br> 12 Bits <br> 14 Bits <br> 16 Bits <br> User Selectable | $-10$ |  | $\begin{aligned} & 1 \\ & +10 \\ & 260 \end{aligned}$ |  | * | $\begin{aligned} & 1 \\ & 1040 \\ & 260 \\ & 65 \\ & 16.25 \end{aligned}$ | LSB <br> Degrees <br> rps <br> rps <br> rps <br> rps |
| ACCURACY <br> Angular Accuracy <br> Monotonicity <br> Missing Codes (16-Bit Resolution) | H <br> K <br> L. Guaranteed Monotonic J, K <br> L | $\cdots$ |  | $\pm 30+1 \mathrm{LSB}$ |  |  | $\begin{aligned} & \pm 22+1 \text { LSB } \\ & \pm 8+1 \text { LSB } \\ & \pm 4+1 \text { LSB } \\ & \pm 2+1 \text { LSB } \\ & 4 \\ & 1 \end{aligned}$ | $\operatorname{arc} \min$ arc min arc min arc min <br> Codes Code |
| VELOCITY SIGNAL <br> Linearity <br> Reversion Error <br> DC Zero Offset ${ }^{2}$ <br> DC Zero Offset Tempco <br> Gain Scaling Accuracy <br> Output Voltage <br> Dynamic Ripple <br> Output Load | Over Full Range <br> 1 mA Load <br> Mean Value | $\pm 8$ | $\begin{aligned} & \pm 1 \\ & -22 \\ & \pm 9 \end{aligned}$ | $\begin{aligned} & \pm 3 \\ & \pm 2 \\ & 6 \\ & \pm 10 \\ & \pm 10.5 \\ & 1.5 \\ & 1.0 \end{aligned}$ |  | $\begin{aligned} & \star \\ & \star \\ & \star \\ & \star \end{aligned}$ |  | \% FSD <br> \% FSD <br> mV <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ <br> \% FSD <br> V <br> \% rms O/P <br> k $\Omega$ |
| INPUT/OUTPUT PROTECTION <br> Analog Inputs <br> Analog Outputs | Overvoltage Protection Short Circuit O/P Protection | $\pm 5.6$ | $\begin{aligned} & \pm 8 \\ & \pm 8 \end{aligned}$ | $\pm 10.4$ |  | * |  | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~mA} \end{aligned}$ |
| DIGITAL POSITION <br> Resolution Output Format Load | $10,12,14$, and 16 Bidirectional Natural Binary |  |  | 3 |  | * |  | LSTTL |
|  | Logic LO to Inhibit |  |  | 600 |  | * |  | ns |
| $\overline{\text { ENABLE }}^{3}$ <br> ENABLE/Disable Time | Logic LO Enables Position Output. Logic HI Outputs in High Impedance State | 35 |  | 110 |  | * |  | ns |
| BYTE SELECT ${ }^{3}$ <br> Sense Logic HI <br> Logic LO <br> Time to Data Available | MS Byte DB1-DB8, <br> (LS Byte DB9-DB16) ${ }^{4}$ <br> LS Byte DB1-DB8, <br> (LS Byte DB9-DB16) ${ }^{4}$ | 60 |  | 140 |  | * |  | ns |
| SHORT CYCLE INPUTS ${ }^{4}$ | Internally Pulled High ( $100 \mathrm{k} \Omega$ ) to $+\mathrm{V}_{\mathrm{S}}$ <br> 10 Bit <br> 12 Bit <br> 14 Bit <br> 16 Bit |  |  | - |  | , | * |  |
| $\begin{aligned} & \text { DATA LOAD }{ }^{4} \\ & \text { Sense } \end{aligned}$ | Internally Pulled High ( $100 \mathrm{k} \Omega$ ) to $+\mathrm{V}_{\mathrm{S}}$; Logic LO Allows Data to Be Loaded into the Counters from the Data Lines |  |  |  |  | 150 | 300 | ns |


| Parameter | Conditions | Min | $\begin{aligned} & \text { D2S81 } \\ & \text { Typ } \end{aligned}$ | Max | Min | $\begin{gathered} \text { AD2S } \\ \text { Typ } \end{gathered}$ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\overline{\text { COMPLEMENT }}{ }^{4}$ | Internally Pulled High ( $100 \mathrm{k} \Omega$ ) to $+\mathrm{V}_{\mathrm{S}}$; Logic LO to Activate; No Connect for Normal Operation |  |  |  |  |  |  |  |
| BUSY $^{3}$ <br> Sense <br> Width <br> Load | Logic HI When Position O/P Changing <br> Use Additional Pull-Up | 200 |  | $\begin{aligned} & 600 \\ & 1 \end{aligned}$ |  | $\star$ |  | $\begin{aligned} & \text { ns } \\ & \text { LSTTL } \end{aligned}$ |
| DIRECTION $^{3}$ Sense Max Load | Logic HI Counting Up Logic LO Counting Down |  |  | 3 |  | $\star$ |  | LSTTL |
| RIPPLE CLOCK ${ }^{3}$ <br> Sense <br> Width <br> Reset <br> Load | Logic HI, All 1s to All 0s <br> All 0s to All 1s <br> Dependent On Input Velocity <br> Before Next Busy | 300 |  | 3 |  | $\star$ |  | LSTTL |
| DIGITAL INPUTS High Voltage, $\mathrm{V}_{\mathrm{IH}}$ Low Voltage, $\mathrm{V}_{\mathrm{IL}}$ | $\overline{\text { INHIBIT }}, \overline{\text { ENABLE }}$ DB1-DB16, Byte Select $\pm \mathrm{V}_{\mathrm{S}}= \pm 10.8 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=5.0 \mathrm{~V}$ INHIBIT, $\overline{\text { ENABLE }}$ DB1-DB16, Byte Select $\pm \mathrm{V}_{\mathrm{S}}= \pm 13.2 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=5.0 \mathrm{~V}$ | 2.0 |  | 0.8 |  |  |  |  |
| DIGITAL INPUTS High Current, $\mathrm{I}_{\mathrm{IH}}$ Low Current, $\mathrm{I}_{\mathrm{IL}}$ | $\overline{\text { INHIBIT }}, \overline{\text { ENABLE }}$ <br> DB1-DB16 $\pm \mathrm{V}_{\mathrm{S}}= \pm 13.2 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=5.5 \mathrm{~V}$ <br> INHIBIT, ENABLE <br> DB1-DB16, Byte Select $\pm \mathrm{V}_{\mathrm{S}}= \pm 13.2 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=5.5 \mathrm{~V}$ |  |  | $\begin{aligned} & \pm 100 \\ & \pm 100 \end{aligned}$ |  |  |  | $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ |
| DIGITAL INPUTS Low Voltage, $\mathrm{V}_{\mathrm{IL}}$ Low Current, $\mathrm{I}_{\mathrm{IL}}$ | $\begin{aligned} & \text { ENABLE }=\mathrm{HI} \\ & \text { SC1, SC2, Data Load } \\ & \pm \mathrm{V}_{\mathrm{S}}= \pm 12.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=5.0 \mathrm{~V} \\ & \hline \text { ENABLE }=\mathrm{HI} \\ & \text { SC1, SC2, Data Load } \\ & \pm \mathrm{V}_{\mathrm{S}}= \pm 12.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=5.0 \mathrm{~V} \end{aligned}$ |  |  | 1.0 $-400$ |  |  |  | V <br> $\mu \mathrm{A}$ |
| DIGITAL OUTPUTS High Voltage, $\mathrm{V}_{\mathrm{OH}}$ Low Voltage, $\mathrm{V}_{\mathrm{OL}}$ | $\begin{aligned} & \text { DB1-DB16; RIPPLE CLK, DIR } \\ & \pm \mathrm{V}_{\mathrm{S}}= \pm 12.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=4.5 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{OH}}=100 \mu \mathrm{~A} \\ & \mathrm{DB} 1-\mathrm{DB} 16, \text { RIPPLE CLK, DIR } \\ & \pm \mathrm{V}_{\mathrm{S}}= \pm 12.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=5.5 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{OL}}=1.2 \mathrm{~mA} \end{aligned}$ | 2.4 |  | 0.4 |  | $\star$ $\star$ $\star$ |  | V |
| THREE-STATE LEAKAGE Current $\mathrm{I}_{\mathrm{L}}$ | $\begin{aligned} & \text { DB1-DB16 Only } \\ & +\mathrm{V}_{\mathrm{S}}= \pm 12.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=5.5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{OL}}=0 \mathrm{~V} \\ & +\mathrm{V}_{\mathrm{S}}= \pm 12.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=5.5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{OH}}=5.0 \mathrm{~V} \end{aligned}$ |  |  | $\begin{aligned} & \pm 100 \\ & \pm 100 \end{aligned}$ |  | * |  | $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ |
| $\begin{aligned} & \hline \text { POWER SUPPLIES } \\ & \text { Voltage Levels } \\ & +\mathrm{V}_{\mathrm{S}} \\ & -\mathrm{V}_{\mathrm{S}} \\ & +\mathrm{V}_{\mathrm{L}} \\ & \text { Current } \\ & +\mathrm{I}_{\mathrm{S}} \\ & +\mathrm{I}_{\mathrm{S}} \\ & +\mathrm{I}_{\mathrm{L}} \end{aligned}$ | $\begin{aligned} & \pm \mathrm{V}_{\mathrm{S}} @ \pm 12 \mathrm{~V} \\ & \pm \mathrm{V}_{\mathrm{S}} \text { @ } \pm 13.2 \mathrm{~V} \\ & \pm \mathrm{V}_{\mathrm{L}} \Subset \pm 5.0 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & +10.8 \\ & -10.8 \\ & +5 \end{aligned}$ | $\begin{aligned} & \pm 12 \\ & \pm 19 \\ & \pm 0.5 \end{aligned}$ | $\begin{aligned} & +13.2 \\ & -13.2 \\ & +13.2 \\ & \pm 23 \\ & \pm 30 \\ & \pm 1.5 \end{aligned}$ |  |  | . | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~mA} \\ & \mathrm{~mA} \\ & \mathrm{~mA} \end{aligned}$ |

## NOTES

${ }^{1}$ Refers to small signal bandwidth.
${ }^{2}$ Output offset dependent on value for R6.
${ }^{3}$ Refer to timing diagram.
${ }^{4}$ AD2S82A only.
*Specifications same as AD2S81A.
Specifications subject to change without notice.
All min and max specifications are guaranteed. Specifications in boldface are tested on all production units at final electrical test.

## RECOMMENDED OPERATING CONDITIONS

Power Supply Voltage ( $+\mathrm{V}_{\mathrm{S}}$ to $-\mathrm{V}_{\mathrm{S}}$ ) . . . . . $\pm 12 \mathrm{~V}$ dc $\pm 10 \%$ Power Supply Voltage $\mathrm{V}_{\mathrm{L}}$. . . . . . . . . . . . . . +5 V dc $\pm 10 \%$ Analog Input Voltage (SIN and COS) . . . . . . . 2 V rms $\pm 10 \%$ Analog Input Voltage (REF) . . . . . . . . . . . . 1 V to 8 V peak Signal and Reference Harmonic Distortion . . . . . . . 10\% (max) Phase Shift Between Signal and Reference . $\pm 10$ Degrees (max) Ambient Operating Temperature Range

Commercial (JD, HP, JP, KP, LP) . . . . . . . $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

## PIN DESIGNATIONS

| MNEMONIC | DESCRIPTION |
| :--- | :--- |
| REFERENCE I/P | REFERENCE SIGNAL INPUT |
| DEMOD I/P | DEMODULATOR INPUT |
| AC ERROR O/P | RATIO MULTIPLIER OUTPUT |
| COS I/P | COSINE INPUT |
| ANALOG GROUND | POWER GROUND |
| SIGNAL GROUND | RESOLVER SIGNAL GROUND |
| SIN I/P | SINE INPUT |
| +V | POSITIVE POWER SUPPLY |
| DB1-DB16 | PARALLEL OUTPUT DATA |
| V | LOGIC POWER SUPPLY |
| ENABLE | LOGIC HI-OUTPUT DATA IN HIGH IMPEDANCE |
|  | STATE, LOGIC, LO PRESENTS DATA TO THE |
| BYTE SELECT | OUTPUT LATCHES. |
| LOGIC HI-MOST SIGNIFICANT BYTE TO DB1-DB8 |  |
| INHIBIT | LOGIC LO-LEAST SIGNIFICANT BYTE TO DB1-DB8. |
| DIGITAL GROUND | LOGIC LO INHIBITS DATA TRANSFER TO OUTPUT |
| SC1-SC2* | LATCHES. |
| DIGITAL GROUND |  |
| BUTA LOAD* | SELECT CONVERTER RESOLUTION |
| BUSY | LOGIC LO DB1-D16 INPUTS |
| DIRECTION | LOGIC HI DB1-D16 OUTPUTS |
| RIPPLE CLOCK | CONVERTER BUSY, DATA NOT VALID WHILE BUSY HI |
| -VGIC STATE DEFINES DIRECTION OF INPUT SIGNAL |  |
| -V | ROTATION |
| VCO I/P | POSITIVE PULSE WHEN CONVERTER OUTPUT |
| INTEGRATOR I/P | CHANGES FROM 1S TO ALL OS OR VICA VERSA |
| INTEGRATOR O/P | NEGATIVE POWER SUPPLY |
| DEMOD O/P | VCO INPUT |
| COMPLEMENT* | INTEGRATOR INPUT |
| VCO O/P* | INTEGRATOR OUTPUT |

*AD2S82A ONLY.

## ORDERING GUIDE

|  | Accuracy | Operating <br> Temperature <br> Range | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD2S81AJD | 30 arc min | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{D}-28$ |
| AD2S82AHP | 22 arc min | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | P-44A |
| AD2S82AJP | 8 arc min | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | P-44A |
| AD2S82AKP | $4 \operatorname{arc} \min$ | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | P-44A |
| AD2S82ALP | $2 \operatorname{arc}$ min | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | P-44A |

* $D=$ Ceramic DIP Package; $P=$ Plastic Leaded Chip Carrier (PLCC) Package. For outline information see Package Information section.

ABSOLUTE MAXIMUM RATINGS ${ }^{1}$ (with respect to GND)


## CAUTION:

1. Absolute Maximum Ratings are those values beyond which damage to the device may occur.
2. Correct polarity voltages must be maintained on the $+V_{S}$ and $-V_{S}$ pins.

PIN CONFIGURATIONS


## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 volts, which readily accumulate on the human body and on test equipment, can discharge without detection. Although devices feature proprietary ESD protection circuitry, permanent damage may still occur on these devices if they are subjected to high energy electrostatic discharges. Therefore, proper precautions are recommended to avoid any performance degradation or loss of functionality.


Variable Resolution, Monolithic Resolver-to-Digital Converter AD2S83

## FEATURES

Monolithic Tracking R/D Converter
High Accuracy Velocity Output
High Max Tracking Rate 1040 RPS (10 Bits)
44-Pin PLCC Package
10-, 12-, 14- or 16-Bit Resolution Set by User
Ratiometric Conversion
Stabilized Velocity Reference
Dynamic Performance Set by User
Industrial Temperature Range Versicins

## APPLICATIONS

## DC and AC Servo Motor Control

## Process Control

Numerical Control of Machine Tools
Robotics
Axis Control

## GENERAL DESCRIPTION

The AD2S83 is a monolithic 10-, 12-, 14 - or 16-bit tracking resolver-to-digital converter contained in a 44-pin PLCC package. It is manufactured on Analog Devices' BiMOS II process that combines the advantages of CMOS logic and bipolar high accuracy linear circuits on the same chip.
The converter allows users to select their own resolution and dynamic performance with external components. This allows the users great flexibility in defining the converter that best suits their system requirements. The converter allows users to select the resolution to be $10,12,14$ or 16 bits and to track resolver signals rotating at up to 1040 revs per second ( $62,400 \mathrm{rpm}$ ) when set to 10 -bit resolution.
The AD2S83 converts resolver format input signals into a parallel natural binary digital word using a ratiometric tracking conversion method. This ensures high noise immunity and tolerance of long leads allowing the converter to be located remote from the resolver.

The position output from the converter is presented via 3-state output pins which can be configured for operations with 8- or 16-bit bus. BYTE SELECT, ENABLE and INHIBIT pins ensure easy data transfer to 8 - and 16-bit data bus, and outputs are provided to allow for cycle or pitch counting in external counters.
A precise analog signal proportional to velocity is also available and will replace a tachogenerator.
The AD2S83 operates over reference frequencies in the range 0 Hz to $20,000 \mathrm{~Hz}$.

## FUNCTIONAL BLOCK DIAGRAM



## PRODUCT HIGHLIGHTS

High Accuracy Velocity Output. A precision analog velocity signal with a typical linearity of $\pm 0.1 \%$ and reversion error less than $\pm 0.3 \%$ is generated by the AD2S83. The provision of this signal removes the need for mechanical tachogenerators used in servo systems to provide loop stabilization and speed control.
Monolithic. A one-chip solution reduces the package size and increases the reliability.
Resolution Set by User. Two control pins are used to select the resolution of the AD 2 S 83 to be $10,12,14$ or 16 bits allowing the user to use the AD 2 S 83 with the optimum resolution for each application.
Ratiometric Tracking Conversion. This technique provides continuous output position data without conversion delay and is insensitive to absolute signal levels. It also provides good noise immunity and tolerance to harmonic distortion on the reference and input signals.
Dynamic Performance Set by the User. By selecting external resistor and capacitor values the user can determine bandwidth, maximum tracking rate and velocity scaling of the converter to match the system requirements. The external components required are all low cost, preferred value resistors and capacitors, and the component values are easy to select using the free component selection software design aid.

## MODELS AVAILABLE

Information on the models available is given in the section "Ordering Information."

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\begin{tabular}{|c|c|c|c|c|c|}
\hline Parameter \& Conditions \& Min \& \[
\begin{aligned}
\& \text { AD2S } \\
\& \text { Typ }
\end{aligned}
\] \& Max \& Units \\
\hline \[
\begin{aligned}
\& \overline{\overline{\text { DATA }} \overline{\text { LOAD }}} \\
\& \text { Sense }
\end{aligned}
\] \& Internally Pulled High via \(100 \mathrm{k} \Omega\) to \(+V_{S}\). Logic LO Allows Data to be Loaded into the Counters from the Data Lines \& \& 150 \& 300 \& ns \\
\hline \begin{tabular}{l}
BUSY \({ }^{6,7}\) \\
Sense \\
Width \\
Load
\end{tabular} \& \begin{tabular}{l}
Logic HI When Position O/P Changing \\
Use Additional Pull-Up (See Figure 2)
\end{tabular} \& 200 \& \& \[
\begin{aligned}
\& 350 \\
\& 1
\end{aligned}
\] \& ns LSTTL \\
\hline \begin{tabular}{l}
DIRECTION \(^{6}\) \\
Sense \\
Max Load
\end{tabular} \& \begin{tabular}{l}
Logic HI Counting Up \\
Logic LO Counting Down
\end{tabular} \& \& \& 3 \& LSTTL \\
\hline \begin{tabular}{l}
RIPPLE CLOCK \({ }^{6}\) \\
Sense \\
Width \\
Reset \\
Load
\end{tabular} \& \begin{tabular}{l}
Logic HI \\
All 1s to All 0s \\
All 0s to All 1s \\
Dependent on Input Velocity \\
Before Next Busy
\end{tabular} \& 300 \& \& 3 \& \begin{tabular}{l}
ns \\
LSTTL
\end{tabular} \\
\hline DIGITAL INPUTS Input High Voltage, \(\mathrm{V}_{\mathrm{IH}}\) Input Low Voltage, \(\mathrm{V}_{\mathrm{IL}}\) \& \begin{tabular}{l}
INHIBIT, \(\overline{\text { ENABLE }}\) \\
DB1-DB16, Byte Select
\[
\pm \mathrm{V}_{\mathrm{S}}= \pm 11.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=5.0 \mathrm{~V}
\] \\
\(\overline{\text { INHIBIT, }}\) ENABLE \\
DB1-DB16, Byte Select
\[
\pm \mathrm{V}_{\mathrm{S}}= \pm 12.6 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=5.0 \mathrm{~V}
\]
\end{tabular} \& 2.0 \& \& 0.8 \& V \\
\hline DIGITAL INPUTS Input High Current, \(\mathrm{I}_{\mathrm{IH}}\) Input Low Current, \(\mathrm{I}_{\mathrm{IL}}\) \& \begin{tabular}{l}
INHIBIT, ENABLE \\
DB1-DB16
\[
\pm \mathrm{V}_{\mathrm{S}}= \pm 12.6 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=5.5 \mathrm{~V}
\] \\
INHIBIT, ENABLE \\
DB1-DB16, Byte Select
\[
\pm \mathrm{V}_{\mathrm{S}}= \pm 12.6 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=5.5 \mathrm{~V}
\]
\end{tabular} \& \& \& \[
\begin{aligned}
\& \pm 100 \\
\& \pm 100
\end{aligned}
\] \& \begin{tabular}{l}
\(\mu \mathrm{A}\) \\
\(\mu \mathrm{A}\)
\end{tabular} \\
\hline DIGITAL INPUTS Low Voltage, \(\mathrm{V}_{\text {IL }}\) Low Current, \(\mathrm{I}_{\mathrm{IL}}\) \& \[
\begin{aligned}
\& \overline{\text { ENABLE }}=\mathrm{HI} \\
\& \text { SC1, SC2, DATA } \\
\& \pm \mathrm{V}_{\mathrm{S}}= \pm 12.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=5.0 \mathrm{~V} \\
\& \overline{\text { ENABLE }}=\mathrm{HI} \\
\& \text { SC1, SC2, } \overline{\text { DATA }} \overline{\text { LOAD }} \\
\& \pm \mathrm{V}_{\mathrm{S}}= \pm 12.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=5.0 \mathrm{~V}
\end{aligned}
\] \& \& \& \[
1.0
\]
\[
-400
\] \& \begin{tabular}{l}
V \\
\(\mu \mathrm{A}\)
\end{tabular} \\
\hline DIGITAL OUTPUTS High Voltage, \(\mathrm{V}_{\mathrm{OH}}\) Low Voltage, \(\mathrm{V}_{\mathrm{OL}}\) \& \begin{tabular}{l}
DB1-DB16 \\
RIPPLE CLK, DIR
\[
\begin{aligned}
\& \pm \mathrm{V}_{\mathrm{S}}= \pm 12.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=4.5 \mathrm{~V} \\
\& \mathrm{I}_{\mathrm{OH}}=100 \mu \mathrm{~A} \\
\& \text { DB1-DB16 } \\
\& \text { RIPPLE CLK, DIR } \\
\& \pm \mathrm{V}_{\mathrm{S}}= \pm 12.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=5.5 \mathrm{~V} \\
\& \mathrm{I}_{\mathrm{OL}}=1.2 \mathrm{~mA}
\end{aligned}
\]
\end{tabular} \& 2.4 \& \& \[
0.4
\] \& V

V <br>
\hline
\end{tabular}

## NOTES

${ }^{1}$ Angular accuracy is not guaranteed $<50 \mathrm{~Hz}$ reference frequency.
${ }^{2}$ Linearity Derates from $500 \mathrm{kHz}-1000 \mathrm{kHz} @ 0.0017 \% / \mathrm{kHz}$.
${ }^{3}$ Refer to Definition of Linearity, "The AD2S83 as a Silicon Tachogenerator."
${ }^{4}$ Worst case reversion error at temperature extremes.
${ }^{5}$ Velocity output offset dependent on value for R6.
${ }^{6}$ Refer to timing diagram.
${ }^{7}$ Busy pulse guaranteed up to a VCO rate of 900 kHz .
All min and max specifications are guaranteed. Specifications in boldface are tested on all production units at final electrical test.
Specifications subject to change without notice.

## AD2S83 - SDEGFFATIONS $\left( \pm V_{S}= \pm 12 \mathrm{~V}\right.$ dc $\pm 5 \% ; \mathrm{V}_{\mathrm{L}}=+5 \mathrm{~V}$ dc $\pm 10 \% ; \mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $\left.+85^{\circ} \mathrm{C}\right)$

| Parameter | Conditions | Min | $\begin{aligned} & \text { AD2S8: } \\ & \text { Typ } \end{aligned}$ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| THREE-STATE LEAKAGE Current $I_{L}$ | $\begin{aligned} & \text { DB1-DB16 Only } \\ & \pm \mathrm{V}_{\mathrm{S}}= \pm 12.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=5.5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{OL}}=0 \mathrm{~V} \\ & \pm \mathrm{V}_{\mathrm{S}}= \pm 12.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{L}}=5.5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{OH}}=5.0 \mathrm{~V} \end{aligned}$ |  |  | $\begin{aligned} & \pm 20 \\ & \pm 20 \end{aligned}$ | $\mu \mathrm{A}$ $\mu \mathrm{A}$ |
| RATIO MULTIPLIER AC Error Output Scaling | $\begin{aligned} & 10 \mathrm{Bit} \\ & 12 \mathrm{Bit} \\ & 14 \mathrm{Bit} \\ & 16 \mathrm{Bit} \end{aligned}$ |  | $\begin{aligned} & 177.6 \\ & 44.4 \\ & 11.1 \\ & 2.775 \end{aligned}$ |  | mV/Bit <br> mV/Bit <br> $\mathrm{mV} /$ Bit <br> mV/Bit |
| PHASE SENSITIVE DETECTOR <br> Output Offset Voltage Gain In Phase In Quadrature Input Bias Current Input Impedance Input Voltage | $\begin{aligned} & \text { w.r.t. REF } \\ & \text { w.r.t. REF } \end{aligned}$ | $\begin{aligned} & -0.882 \\ & 1.0 \end{aligned}$ | $\begin{aligned} & -0.9 \\ & 60 \end{aligned}$ | $\begin{aligned} & \mathbf{1 2} \\ & -0.918 \\ & \pm 0.02 \\ & \mathbf{1 5 0} \\ & \\ & \pm 8 \end{aligned}$ | mV <br> V rms/V dc $\mathrm{V} \mathrm{rms} / \mathrm{V}$ dc nA <br> $\mathrm{M} \Omega$ <br> V |
| INTEGRATOR <br> Open-Loop Gain <br> Dead Zone Current (Hysteresis) <br> Input Offset Voltage <br> Input Bias Current <br> Output Voltage Range | At 10 kHz | $\begin{aligned} & 57 \\ & 90 \\ & \pm 8 \end{aligned}$ | $\begin{aligned} & 60 \\ & 100 \\ & 1 \\ & 60 \end{aligned}$ | $\begin{aligned} & 63 \\ & 110 \\ & 5 \\ & 150 \end{aligned}$ | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{nA} / L S B \\ & \mathrm{mV} \\ & \mathrm{nA} \\ & \mathrm{~V} \end{aligned}$ |
| $\begin{aligned} & \text { VCO } \\ & \text { Maximum Rate } \\ & \text { VCO Rate } \end{aligned}$ | +ve DIR <br> -ve DIR | $\begin{aligned} & 1.1 \\ & 8.25 \\ & 8.25 \end{aligned}$ | $\begin{aligned} & 8.50 \\ & 8.50 \end{aligned}$ |  | MHz <br> $\mathrm{kHz} / \mu \mathrm{A}$ <br> $\mathrm{kHz} / \mu \mathrm{A}$ |
| VCO Power Supply Sensitivity Rate <br> Input Offset Voltage Input Bias Current Input Bias Current Tempco Linearity of Absolute Rate $0 \mathrm{kHz}-500 \mathrm{kHz}$ $500 \mathrm{kHz}-1000 \mathrm{kHz}$ Reversion Error | $\begin{aligned} & +v_{s} \\ & -v_{s} \end{aligned}$ |  | $\begin{aligned} & 3 \\ & 12 \\ & +0.22 \\ & \pm 0.1 \\ & \pm 0.15 \\ & \pm 0.3 \end{aligned}$ | $+0.5$ <br> $-0.5$ <br> 50 <br> $\pm 0.15$ <br> $\pm 1.0$ <br> $\pm 0.5$ | \%/V <br> \%/V <br> mV <br> nA <br> nA ${ }^{\circ} \mathrm{C}$ <br> \% <br> \% <br> \% Output |
| POWER SUPPLIES Voltage Levels $+\mathrm{V}_{\mathrm{S}}$ $-\mathrm{V}_{\mathrm{S}}$ $+\mathrm{V}_{\mathrm{L}}$ Current $\pm \mathrm{I}_{\mathrm{S}}$ $\pm \mathrm{I}_{\mathrm{S}}$ $\pm \mathrm{I}_{\mathrm{L}}$ | $\begin{aligned} & \pm \mathrm{V}_{\mathrm{S}} @ \pm 12 \mathrm{~V} \\ & \pm \mathrm{V}_{\mathrm{S}} \Subset \pm 12.6 \mathrm{~V} \\ & +\mathrm{V}_{\mathrm{L}} \Subset \pm 5.0 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & +11.4 \\ & -11.4 \\ & +4.5 \end{aligned}$ | $\begin{aligned} & +5 \\ & \pm 12 \\ & \pm 19 \\ & \pm 0.5 \end{aligned}$ | $\begin{aligned} & +12.6 \\ & -12.6 \\ & +\mathrm{V}_{\mathrm{S}} \\ & \pm 23 \\ & \pm \mathbf{3 0} \\ & \pm 1.5 \end{aligned}$ | V V V <br> mA <br> mA <br> mA |

All min and max specifications are guaranteed. Specifications in boldface are tested on all production units at final electrical test. Specifications subject to change without notice.

ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Accuracy | Option |
| :--- | :--- | :--- | :--- |

ABSOLUTE MAXIMUM RATINGS ${ }^{1}$ (with respect to GND)


## CAUTION

1. Absolute Maximum Ratings are those values beyond which damage to the device may occur.
2. Correct polarity voltages must be maintained on the $+V_{S}$ and $-V_{S}$ pins.

## RECOMMENDED OPERATING CONDITIONS

Power Supply Voltage ( $+\mathrm{V}_{\mathrm{S}},-\mathrm{V}_{\mathrm{S}}$ ) . . . . . . . $\pm 12 \mathrm{~V}$ dc $\pm 5 \%$ Power Supply Voltage $\mathrm{V}_{\mathrm{L}}$. . . . . . . . . . . . . . +5 V dc $\pm 10 \%$
Analog Input Voltage (SIN and COS) . . . . . $2 \mathrm{~V} \mathrm{rms} \pm 10 \%$
Analog Input Voltage (REF) . . . . . . . . . . . . 1 V to 8 V peak Signal and Reference Harmonic Distortion . . . . . . . 10\% (max)
Phase Shift Between Signal and Reference . $\pm 10$ Degrees (max) Ambient Operating Temperature Range

Industrial (AP) . . . . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$


PIN DESIGNATIONS

| Pin <br> Nos. | Mnemonic | Description |
| :---: | :---: | :---: |
| 1 | DEMOD O/P | Demodulator Output |
| 2 | REFERENCE I/P | Reference Signal Input |
| 3 | AC ERROR O/P | Ratio Multiplier Output |
| 4 | COS | Cosine Input |
| 5 | ANALOG GND | Power Ground |
| 6 | SIGNAL GND | Resolver Signal Ground |
| 7 | SIN | Sine Input |
| 8 | $+\mathrm{V}_{\mathrm{S}}$ | Positive Power Supply |
| 10-25 | DB 1-DB 16 | Parallel Output Data |
| 26 | $+\mathrm{V}_{\text {L }}$ | Logic Power Supply |
| 27 | ENABLE | Logic HI-Output Data Pins in High Impedance State Logic LO-Presents Active Data to the Output Pins |
| 28 | BYTE SELECT | Logic HI-Most Significant Byte to DB1-DB8 <br> Logic LO-Least Significant Byte to DB1-DB8 |
| 30 | $\overline{\text { INHIBIT }}$ | Logic LO Inhibits Data Transfer to Output Latches |
| 31 | DIGITAL GND | Digital Ground |
| 32, 33 | SC2-SC1 | Select Converter Resolution |
| 34 | $\overline{\text { DATA }} \overline{\text { LOAD }}$ | Logic LO DB1-DB16 Inputs Logic HI DB1-DB16 Outputs |
| 35 | COMPLEMENT | Active Logic LO |
| 36 | BUSY | Converter Busy, Data not Valid While Busy HI |
| 37 | DIRECTION | Logic State Defines Direction of Input Signal Rotation |
| 38 | RIPPLE CLOCK | Positive Pulse When Converter Output Changes from 1s to All 0s or Vice Versa |
| 39 | $-\mathrm{V}_{\text {S }}$ | Negative Power Supply |
| 40 | VCO I/P | VCO Input |
| 41 | VCO O/P | VCO Output |
| 42 | INTEGRATOR O/P | Integrator Output |
| 43 | INTEGRATOR I/P | Integrator Input |
| 44 | DEMOD I/P | Demodulator Input |

## ESD SENSITIVITY

The AD2S83 features an input protection circuit consisting of large "distributed" diodes and polysilicon series resistors to dissipate both high energy discharges (Human Body Model) and fast, low energy pulses (Charges Device Model).
Proper ESD precautions are strongly recommended to avoid functional damage or performance degradation. For further information on ESD precautions, refer to Analog Devices ESD Prevention Manual.


Bit Weight Table

| Binary <br> Bits $(\mathbf{N})$ | Resolution <br> $\left(\mathbf{N}^{\mathbf{N}}\right)$ | Degrees <br> $/$ Bit | Minutes <br> /Bit | Seconds <br> /Bit |
| :--- | :---: | :--- | :--- | :--- |
| 0 | 1 | 360.0 | 21600.0 | 1296000.0 |
| 1 | 2 | 180.0 | 10800.0 | 648000.0 |
| 2 | 4 | 90.0 | 5400.0 | 324000.0 |
| 3 | 8 | 45.0 | 2700.0 | 162000.0 |
| 4 | 16 | 22.5 | 1350.0 | 81000.0 |
| 5 | 32 | 11.25 | 675.0 | 40500.0 |
| 6 | 64 | 5.625 | 337.5 | 20250.0 |
| 7 | 128 | 2.8125 | 168.75 | 10125.0 |
| 8 | 256 | 1.40625 | 84.375 | 5062.5 |
| 9 | 512 | 0.703125 | 42.1875 | 2531.25 |
| 10 | 1024 | 0.3515625 | 21.09375 | 1265.625 |
| 11 | 2048 | 0.1757813 | 10.546875 | 632.8125 |
| 12 | 4096 | 0.0878906 | 5.273438 | 316.40625 |
| 13 | 8192 | 0.0439453 | 2.636719 | 158.20313 |
| 14 | 16384 | 0.0219727 | 1.318359 | 79.10156 |
| 15 | 32768 | 0.0109836 | 0.659180 | 39.55078 |
| 16 | 65536 | 0.0054932 | 0.329590 | 19.77539 |
| 17 | 131072 | 0.0027466 | 0.164795 | 9.88770 |
| 18 | 262144 | 0.0013733 | 0.082397 | 4.94385 |

## CONNECTING THE CONVERTER

The power supply voltages connected to $+\mathrm{V}_{\mathrm{S}}$ and $-\mathrm{V}_{\mathrm{S}}$ pins should be +12 V dc and -12 V dc and must not be reversed. The voltage applied to $\mathrm{V}_{\mathrm{L}}$ can be +5 V dc to $+\mathrm{V}_{\mathrm{S}}$.
It is recommended that decoupling capacitors are connected in parallel between the power lines $+\mathrm{V}_{\mathrm{S}},-\mathrm{V}_{\mathrm{S}}$ and ANALOG GROUND adjacent to the converter. Recommended values are 100 nF (ceramic) and $10 \mu \mathrm{~F}$ (tantalum). Also capacitors of 100 nF and $10 \mu \mathrm{~F}$ should be connected between $+\mathrm{V}_{\mathrm{L}}$ and DIGITAL GROUND adjacent to the converter.

When more than one converter is used on a card, separate decoupling capacitors should be used for each converter.
The resolver signal connections should be made to the SIN and COS inputs, REFERENCE INPUT and SIGNAL GROUND as shown in Figure 10 and described in section "CONNECTING THE RESOLVER."

The two signal ground wires from the resolver should be joined at the SIGNAL GROUND pin of the converter to minimize the coupling between the sine and cosine signals. For this reason it is also recommended that the resolver is connected using individually screened twisted pair cables with the sine, cosine and reference signals twisted separately.

SIGNAL GROUND and ANALOG GROUND are connected internally. ANALOG GROUND and DIGITAL GROUND must be connected externally and as close to the converter as possible.

The external components required should be connected as shown in Figure 1.

## CONVERTER RESOLUTION

Two major areas of the AD2S83 specification can be selected by the user to optimize the total system performance. The resolution of the digital output is set by the logic state of the inputs SCl and SC 2 to be $10,12,14$ or 16 bits; and the dynamic characteristics of bandwidth and tracking rate are selected by the choice of external components.
The choice of the resolution will affect the values of R4 and R6 which scale the inputs to the integrator and the VCO respectively (see section COMPONENT SELECTION). If the resolution is changed, then new values of R4 and R6 must be switched into the circuit.
Note: When changing resolution under dynamic conditions, do so when BUSY is low, i.e., when data is not changing.


Figure 1. Connection Diagram

## CONVERTER OPERATION

When connected in a circuit such as shown in Figure 10, the AD2S83 operates as a tracking resolver-to-digital converter. The output will automatically follow the input for speeds up to the selected maximum tracking rate. No convert command is necessary as the conversion is automatically initiated by each LSB increment, or decrement, of the input. Each LSB change of the converter initiates a BUSY pulse.
The AD2S83 is remarkably tolerant of input amplitude and frequency variation because the conversion depends only on the ratio of the input signals. Consequently there is no need for accurate, stable oscillator to produce the reference signal. The inclusion of the phase sensitive detector in the conversion loop ensures high immunity to signals that are not phase or frequency coherent or are in quadrature with the reference signal.

## SIGNAL CONDITIONING

The amplitude of the SINE and COSINE signal inputs should be maintained within $10 \%$ of the nominal values if full performance is required from the velocity signal.
The digital position output is relatively insensitive to amplitude variation. Increasing the input signal levels by more than $10 \%$ will result in a loss in accuracy due to internal overload. Reducing levels will result in a steady decline in accuracy. With the signal levels at $50 \%$ of the correct value, the angular error will increase to an amount equivalent to 1.3 LSB. At this level the repeatability will also degrade to 2 LSB and the dynamic response will also change, since the dynamic characteristics are proportional to the signal level.
The AD2S83 will not be damaged if the signal inputs are applied to the converter without the power supplies and/or the reference.

## REFERENCE INPUT

The amplitude of the reference signal applied to the converter's input is not critical, but care should be taken to ensure it is kept within the recommended operating limits.
The AD2S83 will not be damaged if the reference is supplied to the converter without the power supplies and/or the signal inputs.

## HARMONIC DISTORTION

The amount of harmonic distortion allowable on the signal and reference lines is $10 \%$.
Square waveforms can be used but the input levels should be adjusted so that the average value is 1.9 V rms. (For example, a square wave should be 1.9 V peak.) Triangular and sawtooth waveforms should have a amplitude of 2 V rms.
Note: The figure specified of $10 \%$ harmonic distortion is for calibration convenience only.

## POSITION OUTPUT

The resolver shaft position is represented at the converter output by a natural binary parallel digital word. As the digital position output of the converter passes through the major carries, i.e., all " 1 s " to all " 0 s " or the inverse, a RIPPLE CLOCK (RC) logic output is initiated indicating that a revolution or a pitch of the input has been completed.

The direction of input rotation is indicated by the DIRECTION (DIR) logic output. This direction data is always valid in advance of a RIPPLE CLOCK pulse and, as it is internally latched, only changing state (1 LSB min change in input) with a corresponding change in direction.
Both the RIPPLE CLOCK pulse and the DIRECTION data are unaffected by the application of the INHIBIT. The static positional accuracy quoted is the worst case error that can occur over the full operating temperature excluding the effects of offset signals at the INTEGRATOR INPUT (which can be trimmed out - see Figure 1), and with the following conditions: input signal amplitudes are within $10 \%$ of the nominal; phase shift between signal and reference is less than 10 degrees.
These operating conditions are selected primarily to establish a repeatable acceptance test procedure which can be traced to national standards. In practice, the AD2S83 can be used well outside these operating conditions providing the above points are observed.

## VELOCITY SIGNAL

The tracking converter technique generates an internal signal at the output of the integrator (INTEGRATOR OUTPUT) that is proportional to the rate of change of the input angle. This is a dc analog output referred to as the VELOCITY signal.
It is recommended that the velocity output be buffered.
The sense is positive for an increasing angular input and negative for decreasing angular input. The full-scale velocity output is $\pm 8 \mathrm{~V} \mathrm{dc}$. The output velocity scaling and tracking rate are a function of the resolution of the converter; this is summarized below.

| Res | Max Tracking <br> Rate (rps) | Nominal Scaling <br> $(\mathbf{r p s} / \mathbf{d c})$ |
| :--- | :--- | :--- |
| 10 | 1040 | 130 |
| 12 | 260 | 32.5 |
| 14 | 65 | 8.125 |
| 16 | 16.25 | 2.03 |

(Velocity $\mathrm{O} / \mathrm{P}= \pm 8 \mathrm{~V}$ dc nominal)
The output velocity can be suitably scaled and used to replace a conventional DC tachogenerator. For more detailed information see "AD2S83 as a Silicon Tachogenerator" section.

## DC ERROR SIGNAL

The signal at the output of the phase sensitive detector (DEMODULATOR OUTPUT) is the signal to be nulled by the tracking loop and is, therefore, proportional to the error between the input angle and the output digital angle. As the converter is a Type 2 servo loop, the demodulator output signal will increase if the output fails to track the input for any reason. This is an indication that the input has exceeded the maximum tracking rate of the converter or, due to some internal or external malfunction, the converter is unable to reach a null. By connecting two external comparators, this voltage can be used as a "built-in-test."

## COMPONENT SELECTION

The following instructions describe how to select the external components for the converter in order to achieve the required bandwidth and tracking rate. In all cases the nearest "preferred value" component should be used, and a $5 \%$ tolerance will not degrade the overall performance of the converter. Care should be taken that the resistors and capacitors will function over the required operating temperature range. The components should be connected as shown in Figure 1.
Free PC compatible software is available to help users select the optimum component values for the AD2S83, and display the transfer gain, phase and small step response.
For more detailed information and explanation, see sec-
tion "CIRCUIT FUNCTIONS AND DYNAMIC PERFORMANCE."

1. HF Filter (R1, R2, C1, C2)

The function of the HF filter is to remove any dc offset and to reduce the amount of noise present on the signal inputs to the AD2S83, reaching the Phase Sensitive Detector and affecting the outputs. R1 and C2 may be omitted - in which case $\mathrm{R} 2=\mathrm{R} 3$ and $\mathrm{C} 1=\mathrm{C} 3$, calculated below - but their use is particularly recommended if noise from switch mode power supplies and brushless motor drive is present.
Values should be chosen so that

$$
\begin{gather*}
15 k \Omega \leq R 1=R 2 \leq 56 k \Omega \\
C 1=C 2=\frac{1}{2 \pi R 1 f_{R E F}} \tag{Hz}
\end{gather*}
$$

and $\mathrm{f}_{\text {REF }}=$ Reference frequency
This filter gives an attenuation of 3 times at the input to the phase sensitive detector.
2. Gain Scaling Resistor (R4) (See Phase Sensitive Demodulator Section)
If $\mathrm{R} 1, \mathrm{C} 2$ are fitted then:

$$
R 4=\frac{E_{D C}}{100 \times 10^{-9}} \times \frac{1}{3} \Omega
$$

where $100 \times 10^{-9}=$ current $/ L S B$
If R1, C2 are not fitted then:

$$
R 4=\frac{E_{D C}}{100 \times 10^{-9}} \Omega
$$

where $E_{D C}=160 \times 10^{-3}$ for 10 bits resolution

$$
\begin{aligned}
& =40 \times 10^{-3} \text { for } 12 \text { bits } \\
& =10 \times 10^{-3} \text { for } 14 \text { bits } \\
& =2.5 \times 10^{-3} \text { for } 16 \text { bits } \\
& =\text { Scaling of the DC ERROR in volts/LSB }
\end{aligned}
$$

3. AC Coupling of Reference Input (R3, C3)

Select R3 and C3 so that there is no significant phase shift at the reference frequency. That is,

$$
\begin{gathered}
R 3=100 \mathrm{k} \Omega \\
C 3>\frac{1}{R 3 \times f_{R E F}} F
\end{gathered}
$$

with R3 in $\Omega$.
4. Maximum Tracking Rate (R6)

The VCO input resistor R6 sets the maximum tracking rate of the converter and hence the velocity scaling as at the max tracking rate, the velocity output will be 8 V .

Decide on your maximum tracking rate, " T ," in revolutions per second. When setting the value for R6, it should be remembered that the linearity of the velocity output is specified across $0 \mathrm{kHz}-500 \mathrm{kHz}$ and $500 \mathrm{kHz}-1000 \mathrm{kHz}$. The following conversion can be used to determine the corresponding rps:

$$
r p s=\frac{V C O \text { Rate }(H z)}{2^{N}}
$$

Note that "T" must not exceed the maximum tracking rate or $1 / 16$ of the reference frequency.

$$
R 6=\frac{6.81 \times 10^{10}}{T \times n} \Omega
$$

where $\mathrm{n}=$ bits per revolution

$$
\begin{aligned}
& =1,024 \text { for } 10 \text { bits resolution } \\
& =4,096 \text { for } 12 \text { bits } \\
& =16,384 \text { for } 14 \text { bits } \\
& =65,536 \text { for } 16 \text { bits }
\end{aligned}
$$

5. Closed-Loop Bandwidth Selection (C4, C5, R5)
a. Choose the closed-loop bandwidth ( $\mathrm{f}_{\mathrm{Bw}}$ ) required ensuring that the ratio of reference frequency to bandwidth does not exceed the following guidelines:
Resolution Ratio of Reference Frequency/Bandwidth

| 10 | $2.5: 1$ |
| :--- | :--- |
| 12 | 4 |
| $: 1$ |  |
| 14 | 6 |
| 16 | $7.5: 1$ |

Typical values may be 100 Hz for a 400 Hz reference frequency and 500 Hz to 1000 Hz for a 5 kHz reference frequency.
b. Select C 4 so that

$$
C 4=\frac{21}{R 6 \times f_{B W}{ }^{2}} F
$$

with R6 in $\Omega$ and $\mathrm{f}_{\mathrm{Bw}}$ in Hz selected above.
c. C 5 is given by

$$
C 5=5 \times C 4
$$

d. R5 is given by

$$
R 5=\frac{4}{2 \times \pi \times f_{B W} \times C 5} \Omega
$$

6. VCO Phase Compensation

The following values of C6 and R7 should be connected as close as possible to the VCO output, Pin 41.

$$
C 6=390 p F, R 7=3.3 \mathrm{k} \Omega
$$

7. VCO Optimization

To optimize the performance of the VCO a capacitor, C7, should be placed across the VCO input and output, Pins 40 and 41.

$$
C 7=150 p F
$$

8. Offset Adjust

Offsets and bias currents at the integrator input can cause an additional positional offset at the output of the converter of 1 arc minute typical, 5.3 arc minutes maximum. If this can be tolerated, then R8 and R9 can be omitted from the circuit.
If fitted, the following values of R8 and R9 should be used:
$R 8=4.7 \mathrm{M} \Omega, R 9=1 M \Omega$ potentiometer

To adjust the zero offset, ensure the resolver is disconnected and all the external components are fitted. Connect the COS pin to the REFERENCE INPUT and the SIN pin to the SIGNAL GROUND and with the power and reference applied, adjust the potentiometer to give all " 0 s " on the digital output bits.
The potentiometer may be replaced with select on test resistors if preferred.

## DATA TRANSFER

To transfer data the INHIBIT input should be used. The data will be valid 490 ns after the application of a logic "LO" to the INHIBIT. This is regardless of the time when the INHIBIT is applied and allows time for an active BUSY to clear. By using the ENABLE input the two bytes of data can be transferred after which the INHIBIT should be returned to a logic "HI" state to enable the output latches to be updated.

## BUSY Output

The validity of the output data is indicated by the state of the BUSY output. When the input to the converter is changing, the signal appearing on the BUSY output is a series of pulses at TTL levels. A BUSY pulse is initiated each time the input moves by the analog equivalent of one LSB and the internal counter is incremented or decremented.

## INHIBIT Input

The INHIBIT logic input only inhibits the data transfer from the up-down counter to the output latches and, therefore, does not interrupt the operation of the tracking loop. Releasing the INHIBIT automatically generates a BUSY pulse to refresh the output data.

## ENABLE Input

The ENABLE input determines the state of the output data. A logic "HI" maintains the output data pins in the high impedance condition, and the application of a logic "LO" presents the data in the latches at the output pins. The operation of the $\overline{\text { ENABLE }}$ has no effect on the conversion process.

## BYTE SELECT Input

The BYTE SELECT input selects the byte of the position data to be presented at the data output pins DB1 to DB8. The least significant byte will be presented on data output pins DB9 to DB16 (with the ENABLE input taken to a logic "LO") regardless of the state of the BYTE SELECT pin. Note that when the AD2S83 is used with a resolution less than 16 bits the unused data lines are pulled to a logic "LO." A logic "HI" on the BYTE SELECT input will present the eight most significant data bits on data output pins DB1 through DB8. A logic "LO" will present the least significant byte on data outputs 1 to 8 , i.e., data outputs 1 to 8 will duplicate data outputs 9 to 16 .

The operation of the BYTE SELECT has no effect on the conversion process of the converter.

## RIPPLE CLOCK

As the output of the converter passes through the major carry, i.e., all " 1 s " to all " 0 s " or the converse, a positive going edge on the RIPPLE CLOCK (RC) output is initiated indicating that a revolution, or a pitch, of the input has been completed.
The minimum pulse width of the ripple clock is 300 ns . RIPPLE CLOCK is normally set high before a BUSY pulse and resets before the next positive going edge of the next busy pulse.
The only exception to this is when DIR changes while the RIPPLE CLOCK is high. Resetting of the RIPPLE clock will only occur if the DIR remains stable for two consecutive positive BUSY pulse edges.
If the AD2S83 is being used in a pitch and revolution counting application, the ripple and busy will need to be gated to prevent false decrement or increment (see Figure 2).
RIPPLE CLOCK is unaffected by INHIBIT.


NOTE: DO NOT USE ABOVE CCT WHEN INHIBIT IS LOW.
Figure 2. Diode Transistor Logic Nand Gate


Digital Timing

| Parameter | $\mathrm{T}_{\text {MIN }}{ }^{\text {® }}$ | $\mathrm{T}_{\text {MAX }}{ }^{\text {® }}$ | Condition |
| :---: | :---: | :---: | :---: |
| $\mathrm{t}_{1}$ | 200 | 350 | BUSY WIDTH $\mathrm{V}_{\mathrm{H}}-\mathrm{V}_{\mathrm{H}}$ |
| $\mathrm{t}_{2}$ | 10 | 25 | RIPPLE CLOCK $\mathrm{V}_{\mathrm{H}}$ to BUSY $\mathrm{V}_{\mathrm{H}}$ |
| $\mathrm{t}_{3}$ | 470 | 580 | RIPPLE CLOCK $\mathrm{V}_{\mathrm{L}}$ to Next BUSY $\mathrm{V}_{\mathrm{H}}$ |
| $\mathrm{t}_{4}$ | 16 | 45 | BUSY $\mathrm{V}_{\mathrm{H}}$ to DATA $\mathrm{V}_{\mathrm{H}}$ |
| $\mathrm{t}_{5}$ | 3 | 25 | BUSY $\mathrm{V}_{\mathrm{H}}$ to DATA $\mathrm{V}_{\mathrm{L}}$ |
| $\mathrm{t}_{6}$ | 70 | 140 | INHIBIT $\mathrm{V}_{\mathrm{H}}$ to BUSY $\mathrm{V}_{\mathrm{H}}$ |
| $\mathrm{t}_{7}$ | 485 | 625 | MIN DIR $\mathrm{V}_{\mathrm{H}}$ to BUSY $\mathrm{V}_{\mathrm{H}}$ |
| $\mathrm{t}_{8}$ | 515 | 670 | MIN DIR $\mathrm{V}_{\mathrm{H}}$ to BUSY $\mathrm{V}_{\mathrm{H}}$ |
| $\mathrm{t}_{9}$ | - | 490 | $\overline{\text { INHIBIT }} \mathrm{V}_{L}$ to DATA STABLE |
| $\mathrm{t}_{10}$ | 40 | 110 | $\overline{\text { ENABLE }} \mathrm{V}_{\mathrm{L}}$ to DATA $\mathrm{V}_{\mathrm{H}}$ |
| $\mathrm{t}_{11}$ | 35 | 110 | ENABLE $\mathrm{V}_{\mathrm{L}}$ to DATA $\mathrm{V}_{\mathrm{L}}$ |
| $\mathrm{t}_{12}$ | 60 | 140 | BYTE SELECT $\mathrm{V}_{\mathrm{L}}$ to DATA STABLE |
| $\mathrm{t}_{13}$ | 60 | 125 | BYTE SELECT $\mathrm{V}_{\mathrm{H}}$ to DATA STABLE |

## DIRECTION Output

The DIRECTION (DIR) output indicates the direction of the input rotation. Any change in the state of DIR precedes the corresponding BUSY, DATA and RIPPLE CLOCK updates. DIR can be considered as an asynchronous output and can make multiple changes in state between two consecutive LSB update cycles. This occurs when the direction of rotation of the input changes but the magnitude of the rotation is less than 1 LSB.

## COMPLEMENT

The COMPLEMENT input is an active low input and is internally pulled to $+V_{\mathrm{S}}$ via $100 \mathrm{k} \Omega$.
Strobing $\overline{\text { DATA }} \overline{\text { LOAD }}$ and COMPLEMENT pins to logic LO will set the logic HI bits of the AD2S83 counter to a LO state. Those bits of the applied data which are logic LO will not change the corresponding bits in the AD2S83 counter.

For Example:

| Initial Counter State | 10101 |
| :---: | :---: |
| Applied Data Word | 11000 |
| Counter State after $\overline{\mathrm{DATA}} \overline{\mathrm{LOAD}}$ | 11000 |
| Initial Counter State | 10101 |
| Applied Data Word | 11000 |
| Counter State after DATA LOAD | 0010 |

In order to read the counter following a $\overline{\mathrm{DATA}} \overline{\mathrm{LOAD}}$, the procedure below should be followed:

1. Place Outputs in high impedance state $(\overline{\mathrm{ENABLE}}=\mathrm{HI})$.
2. Present data to pins.
3. Pull $\overline{\text { DATA }} \overline{\text { LOAD }}$ and COMPLEMENT pins to ground.
4. Wait 100 ns .
5. Remove data from pins.
6. Remove outputs from high impedance state ( $\overline{\text { ENABLE }}$ $=\mathrm{LO})$.
7. Read outputs.

## VELOCITY ERRORS

Some "ripple" or noise will always be present in the velocity signal. Velocity signal ripple is caused by, or related to, the following parameters. The resulting effects are generally additive. This means diagnosis needs to be an iterative process in order to define the source of the error.

### 1.0 Reference Frequency

A ripple content at the reference frequency is superimposed on the velocity signal output. The amplitude depends on the loop bandwidth. This error is a function of a dc offset at the input to Phase Sensitive Demodulator (PSD).

### 2.0 Resolver Inaccuracies

Impedance mismatch occur in the sine and cosine windings of the resolver. These give rise to differential phase shift between the sine and cosine inputs to the RDC and variations in the resolver output amplitudes.
2.1 Sine and Cosine Amplitude Mismatch This is normally identified by the presence of asymmetrical ripple voltages.
2.2 Differential Phase Shift between the Sine and Cosine Inputs The frequency of this ripple is usually twice the input velocity, and the amplitude is proportional to the magnitude of the velocity signal. The phase shift is normally induced through the connections from the resolver to the converter. Maintaining equal lengths of screened twisted pair cable from the resolver to the AD 2 S 83 will reduce the effects of resistive imbalance, and therefore, reduce differential phase shift.

### 3.0 LSB Update Ripple

 LSB update noise occurs as the resolver rotates and the digital outputs of the RDC are updated. For a correctly scaled loop, this ripple component has a magnitude of approximately 2 mV peak at 16 -bit resolution.3.1 Ripple due to the LSB rate given by:

LSB rate $=\mathrm{N} \times$ Reference Frequency
The PSD generates sums and differences of all its component input frequencies, so when the LSB update rate is an multiple of the reference frequency, a beat frequency is generated. The magnitude of this ripple is a function of the LSB weighting, i.e., ripple is less at 16 bits.
4.0 Torque Ripple Torque ripple is a phenomenon associated with motors. An ac motor naturally exhibits a sinusoidal back emf. In an ideal system the current fed to the motor should, in order to cancel, also be sinusoidal. In practice the current is often trapezoidal. Consequently, the output torque from the motor will not be smooth and torque ripple is created. If the loading on a motor is constant, the velocity of the motor shaft will vary as a result of the cyclic variation of motor torque. The variation in velocity then appears on the velocity output as ripple. This is not an error but a true velocity variation in the system.

## Offset Errors

The limiting factor in the measuring of low or "creep" speeds is the level of dc offset present at zero velocity. The zero velocity dc offset at the output of the AD2S83 is a function of the input bias current to the VCO and the value for the input resistor R6. See "Circuit Functions and Dynamic Performance VCO."
The offset can be minimized by reducing the maximum tracking rate so reducing the value for R6. Offset is a function of tracking rate and therefore resolution; the dc offset is lowest at 16 bits. To increase the dynamic range of the velocity dynamic resolution switching can be employed. (Contact MCG Applications for more information.)

## CONNECTING THE RESOLVER

The recommended connection circuit is shown in Figure 10.
In cases where the reference phase relative to the input signals from the resolver requires adjustment, this can be easily achieved by varying the value of the resistor R2 of the HF filter (see Figure 1).
Assume that $\mathrm{R} 1=\mathrm{R} 2=\mathrm{R}$ and $\mathrm{C} 1=\mathrm{C} 2=\mathrm{C}$
and Reference Frequency $=\frac{1}{2 \pi R C}$.
By altering the value of R2, the phase of the reference relative to the input signals will change in an approximately linear manner for phase shifts of up to 10 degrees.

Increasing R2 by $10 \%$ introduces a phase lag of 2 degrees. Decreasing R2 by $10 \%$ introduces a phase lead of 2 degrees.


Figure 9. Phase Shift Circuits

## AD2S83

## TYPICAL CIRCUIT CONFIGURATION

Figure 10 shows a typical circuit configuration for the AD2S83 with 12 -bit resolution. Values of the external components have been chosen for a reference frequency of 5 kHz and a maximum tracking rate of 260 rps with a bandwidth of 520 Hz . Placing the values for R4, R6, C4 and C5 in the equation for $\mathrm{K}_{\mathrm{A}}$ gives a value of $2.7 \times 10^{6}$. The resistors are $0.125 \mathrm{~W}, 5 \%$ tolerance preferred values. The capacitors are 100 V ceramic, $10 \%$ tolerance components.

For signal and reference voltages greater than 2 V rms a simple voltage divider circuit of resistors can be used to generate the correct signal level at the converter. Care should be taken to ensure that the ratios of the resistors between the sine signal line and ground and the cosine signal line and ground are the same. Any difference will result in an additional position error.


Figure 10. Typical Circuit Configuration

## FEATURES

Complete Monolithic Resolver-to-Digital Converter Incremental Encoder Emulation (1024-Line)
Absolute Serial Data (12-Bit)
Differential Inputs
12-Bit Resolution
Industrial Temperature Range
20-Pin PLCC
Low Power ( 50 mW )

## APPLICATIONS

Industrial Motor Control
Servo Motor Control
Industrial Gauging
Encoder Emulation
Automotive Motion Sensing and Control
Factory Automation
Limit Switching

## GENERAL DESCRIPTION

The AD2S90 is a complete 12-bit resolution tracking resolver-todigital converter. No external components are required to operate the device.

The converter accepts $2 \mathrm{~V} \mathrm{rms} \pm 10 \%$ input signals in the range $3-20 \mathrm{kHz}$ on the SIN, COS and REF inputs. A Type II servo loop is employed to track the inputs and convert the input SIN and COS information into a digital representation of the input angle. The bandwidth of the converter is set internally at 1 kHz . The maximum tracking rate is 375 rps at 12 -bit resolution.
Angular position output information is available in two forms, absolute serial binary and incremental A quad B.
The absolute serial binary output is 12 -bit ( 1 in 4096). The data output pin is high impedance when Chip Select $\overline{\mathrm{CS}}$ is logic HI. This allows the connection of multiple converters onto a common bus. Absolute angular information in serial pure binary form is accessed by $\overline{\mathrm{CS}}$ followed by the application of an external clock (SCLK) with a maximum rate of 2 MHz .
The encoder emulation outputs A, B and NM continuously produce signals equivalent to a 1024 line encoder. When decoded this corresponds to 12 -bits resolution. Three common north marker pulse widths are selected via a single pin (NMC).
An analog velocity output signal provides a representation of velocity from a rotating resolver shaft travelling in either a clockwise or counterclockwise direction.

FUNCTIONAL BLOCK DIAGRAM


The AD2S 90 operates on $\mathrm{a} \pm 5 \mathrm{~V}$ dc $\pm 5 \%$ power supplies and is fabricated on Analog Devices' Linear Compatible CMOS process (LC ${ }^{2}$ MOS). LC ${ }^{2}$ MOS is a mixed technology process that combines precision bipolar circuits with low power CMOS logic circuits.

## PRODUCT HIGHLIGHTS

Complete Resolver-Digital Interface. The AD2S90 provides the complete solution for digitizing resolver signals (12-bit resolution) without the need for external components.
Dual Format Position Data. Incremental encoder emulation in standard A QUAD B format with selectable North Marker width. Absolute serial 12 -bit angular binary position data accessed via simple 3-wire interface.
Single High Accuracy Grade in Low Cost Package. $\pm 10.6$ arc minutes of angular accuracy available in a 20 -pin PLCC.


| Parameter | Min | Typ | Max | Units | Test Condition |
| :---: | :---: | :---: | :---: | :---: | :---: |
| SIGNAL INPUTS <br> Voltage Amplitude <br> Frequency <br> Input Bias Current <br> Input Impedance <br> Common-Mode Volts ${ }^{1}$ <br> CMRR | $\begin{aligned} & 1.8 \\ & 3 \\ & 1.0 \\ & 60 \end{aligned}$ | 2.0 | $\begin{aligned} & 2.2 \\ & 20 \\ & 100 \\ & 100 \end{aligned}$ | V rms. <br> kHz <br> nA <br> $\mathrm{M} \Omega$ <br> mV peak <br> dB | Differential SIN to SIN LO, COS to COS LO $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=2 \pm 10 \% \mathrm{~V} \mathrm{rms} \\ & \mathrm{~V}_{\mathrm{IN}}=2 \pm 10 \% \mathrm{Vrms} \end{aligned}$ <br> CMV @ SINLO, COSLO w.r.t. AGND @ 10 kHz |
| REFERENCE INPUT <br> Voltage Amplitude <br> Frequency <br> Input Bias Current <br> Input Impedance <br> Permissible Phase Shift | $\begin{aligned} & 1.8 \\ & 3 \\ & 100 \\ & -10 \end{aligned}$ | 2.0 | $\begin{aligned} & 3.35 \\ & 20 \\ & 100 \\ & +10 \end{aligned}$ | V rms <br> kHz <br> nA <br> k $\Omega$ <br> Degrees | Relative to SIN, COS Inputs |
| CONVERTER DYNAMICS <br> Bandwidth <br> Maximum Tracking Rate <br> Maximum VCO Rate (CLKOUT) <br> Settling Time <br> $1^{\circ}$ Step <br> $179^{\circ}$ Step | $\begin{aligned} & 700 \\ & 375 \\ & 1.536 \end{aligned}$ | $840$ | 1000 <br> 7 <br> 20 | Hz <br> rps MHz <br> ms <br> ms |  |
| ACCURACY <br> Angular Accuracy ${ }^{2}$ Repeatability ${ }^{3}$ |  |  | $\begin{aligned} & \pm 10.6+1 \text { LSB } \\ & 1 \end{aligned}$ | arc min LSB |  |
| VELOCITY OUTPUT <br> Scaling <br> Output Voltage at max rps Load Drive Capability | $\begin{aligned} & 127.5 \\ & \pm 2.17 \end{aligned}$ | 150 | $\begin{aligned} & 172.5 \\ & \pm 2.875 \\ & \pm 250 \end{aligned}$ | $\mathrm{rps} / \mathrm{V}$ dc V dc $\mu \mathrm{A}$ | $\mathrm{V}_{\text {OUT }}= \pm 2.5 \mathrm{~V} \mathrm{dc}$ |
| LOGIC INPUTS SCLK, $\overline{\mathrm{CS}}$ Input High Voltage ( $\mathrm{V}_{\mathrm{INH}}$ ) Input Low Voltage ( $\mathrm{V}_{\text {INL }}$ ) Input Current ( $\mathrm{I}_{\mathrm{IN}}$ ) Input Capacitance | 3.5 |  | $\begin{aligned} & 1.5 \\ & 10 \\ & 10 \end{aligned}$ | V dc <br> V dc <br> $\mu \mathrm{A}$ <br> pF | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V} \mathrm{dc}, \mathrm{~V}_{\mathrm{Ss}}=-5 \mathrm{~V} \mathrm{dc} \\ & \mathrm{~V}_{\mathrm{DD}}=+5 \mathrm{Vdc}, \mathrm{~V}_{\mathrm{SS}}=-5 \mathrm{Vdc} \end{aligned}$ |
| LOGIC OUTPUTS DATA, A, B, ${ }^{4}$ NM, CLKOUT, DIR Output High Voltage Output Low Voltage | 4.0 |  | $\begin{aligned} & 1.0 \\ & 0.4 \end{aligned}$ | V dc <br> V dc <br> V dc | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V} \mathrm{dc}, \mathrm{~V}_{\mathrm{Ss}}=-5 \mathrm{~V} \mathrm{dc} \\ & \mathrm{I}_{\mathrm{OH}}=1 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OL}}=1 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OL}}=400 \mu \mathrm{~A} \end{aligned}$ |
| SERIAL CLOCK (SCLK) SCLK Input Rate |  |  | 2 | MHz | 1:1 Mark Space Ratio |
| ```NORTH MARKER CONTROL (NMC) \(90^{\circ}\) \(180^{\circ}\) \(360^{\circ}\)``` | $\begin{aligned} & +4.75 \\ & -0.75 \\ & -4.75 \end{aligned}$ | $\begin{aligned} & +5.0 \\ & \text { DGND } \\ & -5.0 \end{aligned}$ | $\begin{aligned} & +5.25 \\ & +0.75 \\ & -5.25 \end{aligned}$ | V dc <br> V dc <br> V dc | North Marker Width Relative to to "A" Cycle |
| POWER SUPPLIES $\mathbf{V}_{\text {DD }}$ $\mathbf{V}_{\mathbf{S S}}$ $\mathbf{I}_{\text {DD }}$ $\mathbf{I}_{\mathbf{S S}}$ | $\begin{aligned} & +4.75 \\ & -4.75 \end{aligned}$ | $\begin{array}{r} +5.00 \\ -5.00 \end{array}$ | $\begin{aligned} & +5.25 \\ & -5.25 \\ & 7 \\ & 9 \end{aligned}$ | V dc <br> V dc <br> mA <br> mA |  |

## NOTES

${ }^{1}$ If the tolerance on signal inputs $= \pm 5 \%$, then $\mathrm{CMV}=200 \mathrm{mV}$.
${ }^{2} 1$ LSB = 5.3 arc minute.
${ }^{3}$ Specified at constant temperature.
${ }^{4}$ Output load drive capability.
Specifications subject to change without notice.

TIMING CHARACTERISTICS ${ }^{1,2} \underset{\text { diless otherwise noted. }}{\left(V_{\text {DD }}=+5 \mathrm{~V}\right.} \pm 5 \% \mathrm{~V}_{\mathrm{SS}}=-5 \mathrm{~V} \pm 5 \%$, AGND $=\mathrm{DGND}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$


* THE MInimum ACCESS time: USER DEPENDENT

Serial Interface

| Parameter | AD2S90 | Units | Test Conditions/Notes |
| :--- | :--- | :--- | :--- |
| $\mathrm{t}_{1}$ | 150 | $\mathrm{~ns} \max$ | $\overline{\mathrm{CS}}$ to DATA Enable |
| $\mathrm{t}_{2}{ }^{1}$ | 600 | $\mathrm{~ns} \min$ | CS to lst SCLK Negative Edge |
| $\mathrm{t}_{3}$ | 250 | $\mathrm{~ns} \min$ | SCLK Low Pulse |
| $\mathrm{t}_{4}$ | 250 | $\mathrm{~ns} \min$ | SCLK High Pulse |
| $\mathrm{t}_{5}$ | 100 | $\mathrm{~ns} \max$ | SCLK Negative Edge to DATA Valid |
| $\mathrm{t}_{6}$ | 600 | $\mathrm{~ns} \min$ | $\overline{\mathrm{CS}}$ High Pulse Width |
| $\mathrm{t}_{7}$ | 150 | $\mathrm{~ns} \max$ | $\overline{\mathrm{CS}}$ High to DATA High Z (Bus Relinquish) |

${ }^{1}$ SCLK can only be applied after $\mathrm{t}_{2}$ has elapsed.


## NOTES

${ }^{1}$ Timing data are not $100 \%$ production tested. Sample tested at $+25^{\circ} \mathrm{C}$ only to ensure conformance to data sheet limits. Logic output timing tests carried out using $10 \mathrm{pF}, 100 \mathrm{k} \Omega$ load.
${ }^{2}$ Capacitance of data pin in high impedance state $=15 \mathrm{pF}$.

## RECOMMENDED OPERATING CONDITIONS

Power Supply Voltage ( $\mathrm{V}_{\mathrm{DD}}-\mathrm{V}_{\mathrm{ss}}$ ) . . . . . . . . $\pm 5 \mathrm{~V}$ dc $\pm 5 \%$ Analog Input Voltage (SIN, COS \& REF) . . . $2 \mathrm{~V} \mathrm{rms} \pm 10 \%$ Signal and Reference Harmonic Distortion . . . . . . . . . . . 10\%
Phase Shift between Signal and Reference . . . . . . . . . . . $\pm 10^{\circ}$ Ambient Operating Temperature Range

Industrial (AP) . . . . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
ABSOLUTE MAXIMUM RATINGS*
$\mathrm{V}_{\mathrm{DD}}$ to AGND . . . . . . . . . . . . . . -0.3 V dc to +7.0 V dc
$\mathrm{V}_{\text {ss }}$ to AGND . . . . . . . . . . . . . . . . +0.3 V dc to -7.0 V dc
AGND to DGND . . . . . . . . -0.3 V dc to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ dc
Analog Inputs to AGND
REF . . . . . . . . . . . . $\mathrm{V}_{\text {SS }}-0.3 \mathrm{~V}$ dc to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ dc SIN, SIN LO $\ldots . . . V_{\text {Ss }}-0.3 \mathrm{~V}$ dc to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ dc $\operatorname{COS}, \operatorname{COS} \mathrm{LO} \ldots . . \mathrm{V}_{\text {ss }}-0.3 \mathrm{~V}$ dc to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ dc Analog Output to AGND

VEL . . . . . . . . . . . . . . . . . . . . . . . . . . . . . V Vs to V $_{\text {DD }}$
Digital Inputs to DGND, CSB,
SCLK, RES . . . . . . . . . -0.3 V dc to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ dc
Digital Outputs to DGND, NM, A, B,
DIR, CLKOUT DATA . . . -0.3 V dc to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ dc
Operating Temperature Range
Industrial (AP) . . . . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering 10 secs) . . . . . . . . . . . . . $300^{\circ} \mathrm{C}$
Power Dissipation to $+75^{\circ} \mathrm{C}$. . . . . . . . . . . . . . . . . 300 mW
Derates above $+75^{\circ} \mathrm{C}$ by . . . . . . . . . . . . . . . . . . $10 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$
*Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ORDERING INFORMATION

| Model | Temperature Range | Accuracy | Package Option* |
| :--- | :--- | :--- | :--- |
| AD2S90AP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8 arc min | P-20A |

*P = Plastic Leaded Chip Carrier. For outline information see Package Information section.


PIN DESCRIPTIONS

| Pin No. | Mnemonic | Function |
| :---: | :---: | :---: |
| 1 | AGND | Analog ground, reference ground. |
| 2 | SIN | SIN channel noninverting input connect to resolver SIN HI output. SIN to SIN $\mathrm{LO}=2 \mathrm{~V}$ rms $\pm 10 \%$. |
| 3 | SIN LO | SIN channel inverting input connect to resolver SIN LO. |
| 4 | DATA | Serial interface data output. High impedance with $\overline{\mathrm{CS}}=\mathrm{HI}$. Enabled by $\overline{\mathrm{CS}}=0$. |
| 5 | SCLK | Serial interface clock. Data is clocked out on "first" negative edge of SCLK after a LO transition on CS. 12 SCLK pulses to clock data out. |
| 6 | $\overline{\mathrm{CS}}$ | Chip select. Active LO. Logic LO transition enables DATA output. |
| 7 | A | Encoder A output. A leads B for increasing angular rotation. |
| 8 | B | Encoder B output. |
| 9 | NM | Encoder North Marker emulation output. Pulse triggered as code passes through zero. Three common pulse widths available. |
| 10 | DIR | Indicates direction of rotation of input. Logic $\mathrm{HI}=$ increasing angular rotation. Logic LO = decreasing angular rotation. |
| 11 | DGND | Digital power ground return. |
| 12 | $\mathrm{V}_{\text {ss }}$ | Negative power supply, -5 V dc $\pm 5 \%$. |
| 13 | $\mathrm{V}_{\text {DD }}$ | Positive power supply, $+5 \mathrm{~V} \mathrm{dc} \pm 5 \%$. |
| 14 | $\mathrm{V}_{\mathrm{DD}}$ | Positive power supply, +5 V dc $\pm 5 \%$. Must be connected to Pin 13. |
| 15 | NMC | North marker width control. Internally pulled HI via $50 \mathrm{k} \Omega$ nominal. |
| 16 | CLKOUT | Internal VCO clock output. Indicates angular velocity of input signals. Max nominal rate $=1.536 \mathrm{MHz}$. CLKOUT is a 300 ns positive pulse. |
| 17 | VEL | Indicates angular velocity of input signals. Positive voltage w.r.t. AGND indicates increasing angle. $\mathrm{FSD}=375$ rps. |
| 18 | REF | Converter reference input. Normally derived from resolver primary excitation. $\mathrm{REF}=2 \mathrm{~V} \mathrm{rms}$ nominal. <br> Phase shift w.r.t. COS and SIN $= \pm 10^{\circ} \max$ |
| 19 | COS LO | COS channel inverting input. Connect to resolver COS LO. |
| 20 | COS | COS channel noninverting input. Connect to resolver COS HI output. $\mathrm{COS}=2 \mathrm{~V} \mathrm{rms} \pm 10 \%$. |

## ESD SENSITIVITY

The AD2S90 features an input protection circuit consisting of large "distributed" diodes and polysilicon series resistors to dissipate both high energy discharges (Human Body Model) and fast, low energy pulses (Charges Device Model).
Proper ESD precautions are strongly recommended to avoid functional damage or performance degradation. For further information on ESD precautions, refer to Analog Devices ESD Prevention
 Manual.

## RESOLVER FORMAT SIGNALS

A resolver is a rotating transformer which has two stator windings and one rotor winding. The stator windings are displaced mechanically by $90^{\circ}$ (see Figure 1). The rotor is excited with an ac reference. The amplitude of subsequent coupling onto the stator windings is a function of the position of the rotor (shaft) relative to the stator. The resolver, therefore, produces two output voltages (S3-S1, S2-S4) modulated by the SINE and COSINE of shaft angle. Resolver format signals refer to the signals derived from the output of a resolver. Equation 1 illustrates the output form.

$$
\begin{align*}
& S 3-S 1=E_{O} S I N \omega t \cdot \operatorname{SIN} \theta \\
& S 2-S 4=E_{O} S I N \omega t \cdot \operatorname{COS} \theta \tag{1}
\end{align*}
$$

where: $\theta \quad=$ shaft angle
SIN $\omega t=$ rotor excitation frequency
$\mathrm{E}_{\mathrm{O}} \quad=$ rotor excitation amplitude

## Principle of Operation

The AD2S90 operates on a Type 2 tracking closed-loop principle. The output continually tracks the position of the resolver without the need for external convert and wait states. As the transducer moves through a position equivalent to the least significant bit weighting, the output is updated by one LSB.
On the AD2S90, CLKOUT updates corresponding to one LSB increment. If we assume that the current word state of the up-down counter is $\phi, \mathrm{S} 3-\mathrm{S} 1$ is multiplied by $\operatorname{COS} \phi$ and S2-S4 is multiplied by SIN $\phi$ to give:

$$
\begin{align*}
& E_{O} S I N \omega t \cdot \operatorname{SIN} \theta \operatorname{COS} \phi \\
& E_{O} \operatorname{SIN} \omega t \cdot \operatorname{COS} \theta \operatorname{SIN} \phi \tag{2}
\end{align*}
$$

An error amplifier subtracts these signals giving:
$E_{O} \operatorname{SIN} \theta \cdot(\operatorname{SIN} \theta \operatorname{COS} \phi-\operatorname{COS} \theta \operatorname{SIN} \phi)$
or
$E_{O} \operatorname{SIN} \omega t \cdot \operatorname{SIN}(\theta-\phi)$

A phase sensitive detector, integrator and voltage controlled oscillator (VCO) form a closed loop system which seeks to null $\sin (\theta-\phi)$. When this is accomplished the word state of the up/down counter, $\phi$, equals within the rated accuracy of the converter, the resolver shaft angle $\theta$.
For more information on the operation of the converter, see Circuit Dynamics section.


Figure 1. Electrical and Physical Resolver Representation
where $(\theta-\phi)=$ angular error


Figure 2. Connecting the AD2S90 to a Resolver

## AD2S90

## Connecting The Converter

Refer to Figure 2. Positive power supply $\mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V} \mathrm{dc} \pm$ $5 \%$ should be connected to Pin 13 \& Pin 14 and negative power supply $\mathrm{V}_{\mathrm{Ss}}=-5 \mathrm{~V}$ dc $\pm 5 \%$ to Pin 12. Reversal of these power supplies will destroy the device. S3 (SIN) and S2 (COS) from the resolver should be connected to the SIN and COS pins of the converter. S1 (SIN) and S4 (COS) from the resolver should be connected to the SINLO and COSLO pins of the converter. The maximum signal level of either the SIN or COS resolver outputs should be $2 \mathrm{~V} \mathrm{rms} \pm 10 \%$. The AD2S 90 AGND pin is the point at which all analog signal grounds should be star connected. The SIN LO and COS LO pins on the AD2S90 should be connected to AGND. Separate screened twisted cable pairs are recommended for all analog inputs SIN, COS, and REF. The screens should terminate at the converter AGND pin.
North marker width selection is controlled by Pin 15, NMC. Application of $\mathrm{V}_{\mathrm{DD}}, 0 \mathrm{~V}$, or $\mathrm{V}_{\mathrm{SS}}$ to NMC will select standard $90^{\circ}, 180^{\circ}$ and $360^{\circ}$ pulse widths. If unconnected, the NM pulse defaults to $90^{\circ}$. For a more detailed description of the output formats available see the Position Output section.

## ABSOLUTE POSITION OUTPUT

SERIAL INTERFACE
Absolute angular position is represented by serial binary data and is extracted via a three wire interface, DATA, $\overline{\mathrm{CS}}$ and SCLK. The DATA output is held in a high impedance state when $\overline{\mathrm{CS}}$ is HI.
Upon the application of a Logic LO to the $\overline{\mathrm{CS}}$ pin, the DATA output is enabled and the current angular information is transferred from the counters to the serial interface. Data is retrieved by applying an external clock to the SCLK pin. The maximum data rate of the SCLK is 2 MHz . To ensure secure data retrieval it is important to note that SCLK should not be applied until a minimum period of 600 ns after the application of a Logic LO to $\overline{\mathrm{CS}}$. Data is then clocked out, MSB first, on successive negative edges of the SCLK; 12 clock edges are required to extract the full 12 bits of data. Subsequent negative edges greater than the defined resolution of the converter will clock zeros from the data output if $\overline{\mathrm{CS}}$ remains in a low state.
If a resolution of less than 12 bits is required, the data access can be terminated by releasing $\overline{\mathrm{CS}}$ after the required number of bits have been read.


Figure 3. Serial Read Cycle
$\overline{\mathrm{CS}}$ can be released a minimum of 100 ns after the last negative edge. If the user is reading data continuously, $\overline{\mathrm{CS}}$ can be reapplied a minimum of 250 ns after it is released (see Figure 3).

The maximum read time is given by: (12-bits read @ 2 MHz ) Max RD Time $=[600+(12 \times 500)+600+100]=7.30 \mu \mathrm{~s}$.

## INCREMENTAL ENCODER OUTPUTS

The incremental encoder emulation outputs A, B and NM are free running and are always valid, providing that valid resolver format input signals are applied to the converter.

*SELECTABLE WITH THREE - LEVEL
CONTROL PIN " MARKER " DEFAULT TO $90^{\circ}$ USING INTERNAL PULL - UP.

| LEVEL | WIDTH |
| :---: | :---: |
| $+V_{\text {DD }}$ | $90^{\circ}$ |
| 0 | $180^{\circ}$ |
| $-V_{\text {SS }}$ | $360^{\circ}$ |

Figure 4. $A, B \& N M$ Timing

The AD2S90 emulates a 1024 -line encoder. Relating this to converter resolution means one revolution produces $1024 \mathrm{~A}, \mathrm{~B}$ pulses. A leads B for increasing angular rotation. The addition of the DIR output negates the need for external $A$ and $B$ direction decode logic. DIR is HI for increasing angular rotation.
The north marker pulse is generated as the absolute angular position passes through zero. The AD2S90 supports the three industry standard widths controlled using the NMC pin. Figure 4 details the relationship between A, B and NM. The width of NM is defined relative to the A cycle.
Unlike incremental encoders, the AD2S90 encoder output is not subject to error specifications such as cycle error, eccentricity, pulse and state width errors, count density and phase $\varphi$.
The maximum speed rating, $n$, of an encoder is calculated from its maximum switching frequency, $\mathrm{f}_{\text {max }}$, and its ppr (pulses per revolution).

$$
n=\frac{60 \times f_{\max }}{P P R}
$$

The AD2S90 A, B pulses are initiated from CLKOUT which has a maximum frequency of 1.536 MHz . The equivalent encoder switching frequency is:

$$
1 / 4 \times 1.536 \mathrm{MHz}=384 \mathrm{kHz} \text { (4 updates }=1 \text { pulse })
$$

At 12 bits the ppr $=1024$, therefore the maximum speed, $n$, of the AD 2 S 90 is:

$$
n=\frac{60 \times 384000}{1024}=22500 \mathrm{rpm}
$$

This compares favorably with encoder specifications where $f_{\text {max }}$ is specified from 20 kHz (photo diodes) to 125 kHz (laser based)
depending on the light system used. A 1024 line laser-based encoder will have a maximum speed of 7300 rpm .
The inclusion of $\mathrm{A}, \mathrm{B}$ outputs allow the $\mathrm{AD} 2 \mathrm{~S} 90+$ resolver solution to replace optical encoders directly without the need to change or upgrade existing application software.

## VELOCITY OUTPUT

The analog velocity output VEL is scaled to produce $150 \mathrm{rps} / \mathrm{V}$ dc $\pm 15 \%$. The sense is positive V dc for increasing angular rotation. VEL can drive a maximum load combination of $10 \mathrm{k} \Omega$ and 30 pF . The internal velocity scaling is fixed.

## POSITION CONTROL

The rotor movement of dc or ac motors used for servo control is monitored at all times. Feedback transducers used for this purpose detect either relative position in the case of an incremental encoder or absolute position and velocity using a resolver. An incremental encoder only measures change in position not actual position.

## Closed Loop Control Systems

The primary demand for a change in position must take into account the magnitude of that change and the associated acceleration and velocity characteristics of the servo system. This is necessary to avoid "hunting" due to over- or underdamping of the control employed.
A position loop needs both actual and demand position information. Algorithms consisting of proportional, integral and derivative control (PID) may be implemented to control the velocity profile.
A simplified position loop is shown in Figure 5.


Figure 5. Position Loop

## MOTION CONTROL PROCESSES

Advanced VLSI designs mean that silicon system blocks are now available to achieve high performance motion control in servo systems.


Figure 6. Practical Implementation of the AD2S90

A digital position control system using the AD2S90 is shown in Figure 6. In this system the task of determining the acceleration and velocity characteristics is fulfilled by programming a trapezoidal velocity profile via the I/O port.
As can be seen from Figure 6 encoder position feedback information is used. This is a popular format and one which the AD2S90 emulates thereby facilitating the replacement of encoders with an AD2S90 and a resolver. However, major benefits can be realized by adopting the resolver principle as opposed to the incremental technique.
Incremental feedback based systems normally carry out a periodic check between the position demanded by the controller and the increment position count. This requires software and hardware comparisons and battery backup in the case of power failure. If there is a supply failure and the drive system moves, unless all parts of the system are backed up, a reset to a known datum point needs to take place. This can be extremely hazardous in many applications. The AD2S90 gets round this problem by supplying an absolute position serial data stream upon request, thus removing the need to reset to a known datum.

## DSP Interfacing

The AD2S90 serial output is ideally suited for interfacing to DSP configured microprocessors. Figures 7 to 10 illustrate how to configure the AD2S90 for serial interfacing to the DSP. In all cases the AD 2 S 90 is configured for 12-bit operation.

## ADSP-2105 Interfacing

Figure 7 shows the AD2S90 interfaced to an ADSP-2105. The on-chip serial port of the ADSP-2105 is used in alternate framing receive mode with internal framing (internally inverted) and internal serial clock generation (externally inverted) options selected. In this mode the ADSP-2105 provides a $\overline{\mathrm{CS}}$ and a serial clock to the AD2S90. The serial clock is inverted to prevent timing errors as a result of both the AD2S90 and ADSP2105 clock data on the negative edge of SCLK. The first data bit is void; 12-bits of significant data then follow on each consecutive negative edge of the clock. Data is clocked from the AD2S90 into the data receive register of the ADSP-2105. This is internally set to 13 bit ( 12 bits and one "dummy" bit) when 13 bits are received. The serial port automatically generates an internal processor interrupt. This allows the ADSP-2105 to read 12 significant bits at once and continue processing.
The ADSP-2101, ADSP-2102, ADSP-2111 and 21 msp 50 can all interface to the AD2S90 with similar interface circuitry.


Figure 7. ADSP-2105/AD2S90 Serial Interface

## TMS32020 Interfacing

Figure 8 shows the serial interface between the AD2S90 and the TMS32020. The interface is configured in alternate internal framing, external clock (externally inverted) mode. Sixteen bits of data are clocked from the AD2S90 into the data receive register (DDR) of the TMS32020. The DRR is fixed at 16 bits. To obtain the 12 -significant bits, the processor needs to execute three right shifts. (First bit read is void, the last three will be zeros). When 16 bits have been received by the TMS32020, it generates an internal interrupt to read the data from the DRR.


* ADDITIONAL PINS OMITTED FOR CLARITY

Figure 8. TMS32020/AD2S90 Serial Interface

## DSP56000 Interface

Figure 9 shows a serial interface between the AD2S90 and the DSP56000. The DSP in configured for normal mode synchronous operation with gated clock with SCK and SCI as outputs. SCI is applied to $\overline{\mathrm{CS}}$.


* ADDITIONAL PINS OMITTED FOR CLARITY

Figure 9. DSP56000/AD2S90 Serial Interface
The DSP56000 assumes valid data on the first falling edge of SCK. SCK is inverted to ensure that the valid data is clocked in after one leading bit. The receive data shift register (SRD) is set for a 13 -bit word.
When this register has received 13 bits of data, it generates an internal interrupt on the DSP56000 to read the 12-bits of significant data from the register.

## NEC7720 Interface

Figure 10 shows the serial interface between the NEC7720 and the AD2S90. The NEC7720 expects data on the rising edge of its SCK output, and therefore unlike the previous interfaces no inverter is required to clock data into the SI register. There is no need to ignore the first data bit read. $\overline{\text { SIEN }}$ is used to Chip

Select the AD2S90 and frame the data. The SI register is fixed at 16 bits, therefore, to obtain the 12 -significant bits the processor needs to execute four right shifts. Once the NEC7720 has read 16 bits, an internal interrupt is generated to read the internal contents of the SI register.


* ADDITIONAL PINS OMITTED FOR CLARITY

Figure 10. $\mu$ PD7720/AD2S90 Serial Interface
EDGE TRIGGERED $4 \times$ DECODING LOGIC
In most data acquisition or control systems the A, B incremental outputs must be decoded into absolute information, normally a parallel word, before they can be utilized effectively.
To decode the A, B outputs on the AD2S90 the user must implement a $4 \times$ decoding architecture. The principle states that one A, B cycle represents 4 LSB weighted increments of the converter (see Equation 4).

$$
\begin{align*}
& U p=(\uparrow A) \cdot B+(\downarrow A) \cdot B+(\uparrow B) \cdot A+(\downarrow B) \cdot A \\
& \text { Down }=(\uparrow A) \cdot B+(\uparrow A) \cdot B+(\uparrow B) \cdot A+(\downarrow B) \cdot A(4 \tag{4}
\end{align*}
$$



Figure 11. Principles of $4 \times$ Decoding
The algorithms in Equation 4 can be implemented using the architecture shown in Figure 12. Traditionally the direction of the shaft is decoded by determining whether A leads B. The AD2S90 removes the need to derive direction by supplying a direction output state which can be fed straight into the up-down counter.
For further information on this topic please refer to the application note "Circuit Applications of the AD2S90 Resolver-toDigital Converters."


Figure 12. $4 \times$ Decoding Incremental to Parallel Conversion

## REMOTE MULTIPLE SENSOR INTERFACING

The DATA output of the AD2S90 is held in a high impedance state until $\overline{\mathrm{CS}}$ is taken LO. This allows a user to operate the AD2S90 in an application with more than one converter connected on the same line. Figure 13 shows four resolvers interfaced to four AD2S90s. Excitation for the resolvers is provided locally by an oscillator.

SCLK, DATA and two address lines are fed down low loss cables suitable for communication links. The two address lines are decoded locally into $\overline{\mathrm{CS}}$ for the individual converters. Data is received and transmitted using transmitters and receivers.


Figure 13. Remote Sensor Interfacing

## CIRCUIT DYNAMICS/ERROR SOURCES

## Transfer Function

The AD2S90 operates as a Type 2 tracking servo loop. An integrator and VCO/counter perform the two integrations inherent in a Type 2 loop.
The overall system response of the AD 2 S 90 is that of a unity gain second order low-pass filter, with the angle of the resolver as the input and the digital position data as the output. Figure 14 illustrates the AD 2 S 90 system diagram.


Figure 14. AD2S90 Transfer Function

The open loop transfer function is given by;

$$
\begin{equation*}
\frac{\theta_{O U T}}{\theta_{I N}}=\frac{K_{1} K_{2}}{s^{2}} \frac{\left(1+s t_{1}\right)}{1+s t_{2}} \tag{5}
\end{equation*}
$$

where:

$$
A_{1}(s)=\frac{K_{1}}{s} \frac{1+s t_{1}}{1+s t_{2}} \quad \begin{array}{ll}
t_{1} & =1.0 \mathrm{~ms}  \tag{6}\\
t_{2} & =90 \mu \mathrm{~s}
\end{array}
$$

$$
A_{2}(s)=\frac{K_{2}}{s} \quad \begin{align*}
& K_{1}=364 \mathrm{~s}^{-2}  \tag{7}\\
& K_{2}=200,000 \mathrm{~s}^{-2}
\end{align*}
$$

The AD2S90 acceleration constant is given by:

$$
\begin{equation*}
K_{a}=K_{1} \cdot K_{2}=72.8 \times 10^{6} \mathrm{sec}^{-2} \tag{8}
\end{equation*}
$$

The AD2S90's design has been optimized with a critically damped response. The closed-loop transfer function is given by:

$$
\begin{equation*}
\frac{\theta_{O U T}}{\theta_{I N}}=\frac{1+s t_{1}}{1+s t_{1}+\frac{s_{2}}{K_{1} K_{2}}+\frac{s_{3} t_{2}}{K_{1} K_{2}}} \tag{9}
\end{equation*}
$$

The normalized gain and phase diagrams are given in Figures 15 and 16 .


Figure 15. AD2S90 Gain Plot


Figure 16. AD2S90 Phase Plot

The small step response is given in Figure 17, and is the time taken for the converter to settled to within 1 LSB.

$$
\mathrm{ts}=7.00 \mathrm{~ms} \text { (12-bit resolution) }
$$

The large step response (steps $>20^{\circ}$ ) applies when the error voltage will exceed the linear range of the converter. Typically it will take three times longer to reach the first peak for a $179^{\circ}$ step.
In response to a velocity step [VELOUT/(d $\theta / \mathrm{dt})$ ] the velocity output will exhibit the same response characteristics as outlined above.


Figure 17. Small Step Response

## SOURCES OF ERROR

## Acceleration Error

A tracking converter employing a Type 2 servo loop does not suffer any velocity lag, however, there is an additional error due to acceleration. This additional error can be defined using the acceleration constant $K_{a}$ of the converter.

$$
\begin{equation*}
K_{a}=\frac{\text { Input Acceleration }}{\text { Error in Output Angle }} \tag{10}
\end{equation*}
$$

The numerator and denominator's units must be consistent. $K_{a}$ does not define maximum input acceleration, only the error due to its acceleration. The maximum acceleration allowable before the converter loses track is dependent on the angular accuracy requirements of the system.

$$
\begin{equation*}
\text { Angular Error } \times K_{a}=\text { degrees } / \sec 2 \tag{11}
\end{equation*}
$$

$\mathrm{K}_{\mathrm{a}}$ can be used to predict the output position error for a given input acceleration. The AD2S90 has a fixed $\mathrm{K}_{\mathrm{a}}=72.8 \times 10^{6}$ $\mathrm{sec}^{-2}$ if we apply an input accelerating at $100 \mathrm{revs} / \mathrm{sec}^{2}$ in 12-bit mode.

$$
\begin{align*}
& \text { Error in } L S B s=\frac{\text { Input Acceleration }[L S B / \mathrm{sec} 2]}{K_{a}\left[\mathrm{sec}^{-2}\right]} \\
& =\frac{100[\mathrm{rev} / \mathrm{sec} 2] \times 2^{12}}{72.8 \times 10^{6}}=5.62 \times 10^{-3} \mathrm{LSBs} \tag{12}
\end{align*}
$$

FEATURES
Full Function Monolithic LVDT-to-Digital Converter Absolute Serial Data Output
Uncommitted Differential Input
Repeatability
Remote Diagnostics
14-Bit Resolution
Industrial Temperature Range
28-Pin PLCC
Low Power
APPLICATIONS
Industrial Gauging
Industrial Process Control
Linear Positioning Systems
Linear Actuator Control
Automotive Motion Sensing and Control
Torque Sensing Conditioner
AC Strain Gages Conditioning
Avionics

## GENERAL DESCRIPTION

The AD2S93 is a complete 14-bit resolution tracking LVDT-todigital converter. A Type II tracking loop is employed to track the $\mathrm{A}-\mathrm{B}$ input and produce a digital output equal to (A-B)/
( $\mathrm{REF} / 2$ ), where REF is a fixed amplitude ac reference phase coherent with the A-B input. This allows the measurement of any 2-, 3-, 4- and 5-wire LVDT or linear amplitude modulated input. The operating frequency range is from 360 Hz to 10 kHz with user definable bandwidth set externally within a range of 45 Hz to 1250 Hz .
The AD2S 93 has a 16-bit serial output. The MSB (LOS), read first, indicates a loss of the signal $A, B$, or reference inputs to the converter or transducer. The second and third MSBs are flags indicating whether $[-\mathrm{REF} / 2$ (UNR) $\leq \mathrm{A}-\mathrm{B} \leq+\mathrm{REF} / 2$ (OVR]) is outside the linear operating range of the converter. The displacement data is presented as 13-bit offset binary giving a $\pm 12$ bit operating range. LOS, OVR and UNR are pinned out on the device, in addition a NULL flag is available which is set when $(A-B)=0$.
Absolute displacement information is accessed when $\overline{\mathrm{CS}}$ is taken LO followed by the application of an external clock (SCLK) with a maximum rate of 2 MHz . Data is read MSB first. When $\overline{\mathrm{CS}}$ is high the DATA output is high impedance; this allows daisy chaining of more than one converter onto a common bus. The A, B differential input allows the user to scale the A, B inputs between 1 and 10 . This enables the user to accurately set up the inputs matching the REF input to the DIFF output. The

FUNCTIONAL BLOCK DIAGRAM


DIFF output is the resultant A-B. The AD2S93 operates using $\pm 5 \mathrm{~V} \pm 5 \%$ power supplies and is fabricated on Analog Devices' linear compatible CMOS process ( $\mathrm{LC}^{2} \mathrm{MOS}$ ). The ( $\mathrm{LC}^{2} \mathrm{MOS}$ ) is a mixed technology process that combines precision bipolar circuits with low power logic.

## PRODUCT HIGHLIGHTS

Complete LVDT-to-Digital Interface. The AD2S93 provides the complete solution for digitizing LVDT signals to 14bit resolution.
Serial 16-Bit Output Data. One 16-bit read from the underrange detection and 13 bits of offset binary displacement information.
High Accuracy Grade in Low Cost Package. 0.05\% and $0.1 \%$ integral linearity over the full $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ operating temperature range.
Uncommitted Differential Input. Allows configuration of 2-, 3-, 4- and 5-wire LVDTs.
Multiple Converter Interfacing. High impedance data output and a simple three-wire interface reduces cabling and eliminates bus contention.
Low Power. 70 mW power consumption (typ).

| Parameter | Test Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| SIGNAL INPUTS <br> Frequency <br> Max Voltage Level ${ }^{1}$ <br> Nominal Full Scale ${ }^{2}$ <br> Input Bias Current <br> Input Impedance <br> CMRR <br> Maximum Sensitivity ${ }^{3}$ | @ $+25^{\circ} \mathrm{C}$ $\mathrm{V}_{\mathrm{A}-\mathrm{B}}=1 \mathrm{Vrms}, \mathrm{G}=1$ | $\begin{aligned} & 0.36 \\ & 0.8 \end{aligned}$ | $\begin{aligned} & 1.0 \\ & 1.0 \\ & 1.0 \\ & 1.0 \\ & 57 \\ & 342 \\ & \hline \end{aligned}$ | $\begin{aligned} & 10 \\ & 1.2 \\ & 1.1 \end{aligned}$ | kHz <br> V rms <br> V rms <br> $\mu \mathrm{A}$ <br> M $\Omega$ <br> dB <br> $\mu \mathrm{V} \mathrm{pk} / \mathrm{LSB}$ |
| REFERENCE INPUT <br> Frequency <br> Voltage Level <br> Input Bias Current <br> Input Impedance Permissible Phase Shift ${ }^{4}$ | @ 0 V $+25^{\circ} \mathrm{C}$ <br> Signal to Reference | $\begin{gathered} 0.36 \\ 1.8 \\ -10 \end{gathered}$ | $\begin{aligned} & 2.0 \\ & 1.0 \end{aligned}$ | $\begin{aligned} & 10 \\ & 2.2 \\ & 1 \\ & +10 \end{aligned}$ | kHz <br> V rms <br> $\mu \mathrm{A}$ <br> $\mathrm{M} \Omega$ <br> Degrees |
| ```CONVERTER DYNAMICS Bandwidth VCO Mode \(=1\) VCO Mode \(=2\) Maximum Slew Rate Mode \(=1\) Mode \(=2\)``` | Set by User <br> VCO Gain Connected to <br> VCO I/P <br> VCO Gain No Connect | $\begin{aligned} & 500 \\ & 45 \end{aligned}$ | $\begin{aligned} & 2400 \\ & 800 \end{aligned}$ | $\begin{aligned} & 1250 \\ & 500 \\ & 3000 \\ & 1000 \end{aligned}$ | Hz Hz <br> LSB/ms <br> LSB/ms |
| ACCURACY <br> Integral Linearity <br> Differential Linearity <br> Repeatability Zero Position Offset <br> Gain Error | AP <br> BP <br> AP <br> BP <br> AP @ $+25^{\circ} \mathrm{C}$ <br> BP @ $+25^{\circ} \mathrm{C}$ <br> AP @ $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ <br> BP @ $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\begin{aligned} & -3 \\ & -1 \\ & -4 \\ & -2 \end{aligned}$ |  | $\begin{aligned} & 0.1 \\ & 0.05 \\ & <2 \\ & <1 \\ & \pm 1 \\ & 3 \\ & 1 \\ & 4 \\ & 2 \\ & \pm 0.7 \end{aligned}$ | \% FSD \% FSD LSB LSB LSB LSB LSB LSB LSB \% FS |
| VELOCITY OUTPUT Max Output Voltage Load Drive Capability | Denotes Max Input Speed |  |  | $\begin{aligned} & \pm 4.0 \\ & \pm 250 \end{aligned}$ | $\mathrm{V} \text { dc }$ $\mu \mathrm{A}$ |
| LOGIC INPUTS SCLK, $\overline{\mathrm{CS}}$ Input High Voltage $\mathrm{V}_{\text {INH }}$ Input Low Voltage $\mathrm{V}_{\mathrm{INL}}$ Input Current $\mathrm{I}_{\text {IN }}$ Input Capacitance |  | 3.5 |  | $\begin{aligned} & 1.5 \\ & 500 \end{aligned}$ | V dc V dc nA pF |
| LOGIC OUTPUTS <br> OVR, UNR, NULL, DATA, A, B CLKOUT DIR <br> Output High Voltage <br> Output Low Voltage | $\begin{aligned} & @ 1 \mathrm{~mA} \\ & @ 1 \mathrm{~mA} \end{aligned}$ | 4.0 |  | 1.0 | $\begin{aligned} & \mathrm{V} \mathrm{dc} \\ & \mathrm{~V} \mathrm{dc} \end{aligned}$ |
| LOS OUTPUT <br> Drive Capability Signal Threshold (A-B) REF Threshold Timeout Threshold | Open Drain Output Pull-Up to $+\mathrm{V}_{\mathrm{DD}}$ via $12 \mathrm{k} \Omega$ | 0.1 | 0.22 | 400 0.2 50 | $\mu \mathrm{A}$ <br> V rms <br> V rms <br> ms |


| Parameter | Test Conditions | Min | Typ | Max | Units |
| :--- | :---: | :---: | :---: | :---: | :---: |
| SERIAL CLOCK (SCLK) |  |  |  |  |  |
| SCK Input Rate |  |  | 2 | MHz |  |
| Maximum Read Rate (16 Bits) | Continuous |  | 9.2 | $\mu \mathrm{~s}$ |  |
| POWER SUPPLY |  | 5 | 7 | 10 | mA |
| $\mathrm{I}_{\mathrm{DD}}$ |  | 5 | 7 | 10 | mA |
| $\mathrm{I}_{\mathrm{SS}}$ |  |  |  |  |  |

NOTES
${ }^{1}$ The signal input voltage maximum should always be set at $10 \%$ less than the reference input.
${ }^{2}$ Nominal $+\mathrm{FS}=\mathrm{V}_{\mathrm{A} \cdot \mathrm{B}}=\mathrm{V}_{\mathrm{REF}} / 2, \mathrm{FS}=-\mathrm{V}_{\mathrm{A} \cdot \mathrm{B}}=\mathrm{V}_{\mathrm{REF}} / 2$
${ }^{3}$ With $\mathrm{G}=10$; Sensitivity $34.2 \mu \mathrm{~V} \mathrm{pk} / \mathrm{LSB}$
${ }^{4}$ Phase shift cause gain errors. "See Phase Shift and Quadrative Effects."
Specifications subject to change without notice.

## 

| Parameter | AD2S93 | Units | Test Conditions |
| :--- | :--- | :--- | :--- |
| $\mathrm{t}_{1}{ }^{1}$ | 150 | $\mathrm{~ns} \max$ | $\overline{\mathrm{CS}}$ to DATA Enable |
| $\mathrm{t}_{2}$ | 600 | $\mathrm{~ns} \min$ | $\overline{\mathrm{CS}}$ to 1st SCLK Positive Edge |
| $\mathrm{t}_{3}$ | 250 | $\mathrm{~ns} \min$ | SCLK High Pulse |
| $\mathrm{t}_{4}$ | 250 | $\mathrm{~ns} \min$ | SCLK Low Pulse |
| $\mathrm{t}_{5}$ | 100 | $\mathrm{~ns} \max$ | $\overline{\text { SCLK Positive Edge to DATA Valid }}$ |
| $\mathrm{t}_{6}$ | 600 | $\mathrm{~ns} \min$ | $\overline{\mathrm{CS}}$ High Pulse Width |
| $\mathrm{t}_{7}$ | 150 | $\mathrm{~ns} \max$ | $\overline{\mathrm{CS}}$ High to DATA High Z (Bus Relinquish) |

NOTE
${ }^{1}$ SCLK can only be applied after $\mathrm{t}_{2}$ has elapsed.


[^239]
## RECOMMENDED OPERATING CONDITIONS

| Power Supply Vorage ( $\mathrm{V}_{\text {DD }}-\mathrm{V}_{\text {ss }}$ ) |  |
| :---: | :---: |
| Analog Input Voltage (A, B) | $1 \mathrm{Vrms} \pm 10 \%$ |
| Analog Reference Input (REF) | 2 V rms $\pm 10 \%$ |
| Signal and Reference Harmonic Distortion | 0\% |
| Operating Temperature Range |  |
| Industrial (AP, BP) | $40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |

## ABSOLUTE MAXIMUM RATINGS*

V $_{\text {DD }}$ to AGND . . . . . . . . . . . . . . . . . . -0.3 V dc to +7.0 V dc $\mathrm{V}_{\text {SS }}$ to AGND . . . . . . . . . . . . . . . . . . +0.3 V dc to -7.0 V dc AGND to DGND . . . . . . . . . . . -0.3 V dc to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ dc Analog Inputs to AGND REF .... $\mathrm{V}_{\mathrm{Ss}}-0.3 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ A, B ............................ . . $\mathrm{V}_{\mathrm{Ss}}-0.3 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ Analog Output to AGND VEL . . . . . . . . . . . . . . . $\mathrm{V}_{\mathrm{SS}}$ to $\mathrm{V}_{\mathrm{DD}}$ Digital Inputs to DGND
$\overline{C S}$, SCLK . . . . . . . . . . . . . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Digital Outputs to DGND
NULL, DIR, CLKOUT, DATA .... -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Operating Temperature Range
Industrial (A, B) . . . . . . . . . . . . . . . . . . . . $40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ Lead Temperature (Soldering 10 sec ) . . . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Power Dissipation to $+75^{\circ} \mathrm{C}$. . . . . . . . . . . . . . . . . . +100 mW
Derates above $+75^{\circ} \mathrm{C}$ by . . . . . . . . . . . . . . . . . . . . . $10 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.


ORDERING GUIDE

| Model | Temperature <br> Range | Linearity | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD2S93AP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $0.1 \%$ | P-28A |
| AD2S93BP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $0.05 \%$ | P-28A |

*For outline information see Package Information section.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD2S93 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

PIN DESIGNATIONS

| Pin <br> No. | Mnemonic | Description |
| :---: | :---: | :---: |
| 1 | AGND | Analog Ground. |
| 2 | DIFF | Output of Signal Input Preamplifier. |
| 3 | GAIN | Connect GAIN Pin to DIFF for nominal $\times 1$. Gains greater than 1 can be resistively scaled. Do not leave unconnected. |
| 4 | LOS | Denotes A or B lines loss of connection and/or loss of reference to transducer or converter. |
| 5 | DATA | 16-bit serial data output 13 bits of absolute position information plus overrange and underrange plus LOS. |
| 6 | SCLK | Serial Clock. Maximum rate $=2 \mathrm{MHz}$. |
| 7 | $\overline{\mathrm{CS}}$ | Chip Select. Loads serial interface with current positional information and enable output. |
| 9, 12 | UNR, OVR | Two pins that denote whether the input signals are underrange or overrange. |
| 10 | CLKOUT | Updates every LSB. |
| 13 | NULL | Denotes Null Position. |
| 14 | DIR | Indicates direction. DIR is HI for positive displacement and LO for negative displacement. |
| 15 | DGND | Digital Ground. |
| 16 | $\mathrm{V}_{\text {ss }}$ | Negative Power Supply -5.0 V dc $\pm 5 \%$. |
| 17 | $\mathrm{V}_{\mathrm{DD}}$ | Positive Power Supply +5.0 V dc $\pm 5 \%$. |
| 18 | DEMODOUT | Output of the Phase Sensitive Demodulator. |
| 19 | DEMODIN | Input to Phase Sensitive Demodulator. |
| 20 | ACERROR | AC Error Output. |
| 21 | VCO GAIN | Sets the VCO gain internally. Connect to VEL for $2400 \mathrm{LSB} / \mathrm{s}$. Disconnect for $800 \mathrm{LSB} / \mathrm{s}$. |
| 22 | INTIN | Determines system dynamics connect C and RC (serial) parallel combination across INTIN and VEL to determine loop dynamics. |
| 23 | VEL | Analog Velocity Output. |
| 24 | REF | Single ended input for fixed amplitude reference. |
| 27, 28 | B, A | Uncommitted differential inputs for the $\mathrm{A}, \mathrm{B}$ signal inputs. |

## GLOSSARY OF TERMS

## INTEGRAL LINEARITY

Integral linearity deviation as a percent of full scale. A $0.1 \%$ deviation is equivalent to 8 -LSB change on the output.

## Gain

The converter gain is the maximum variation in the ratio of $A-B / R E F / 2$ to the maximum digital input.

## Output Offset

The output offset is the digital output code when the analog input signal $\mathrm{A}-\mathrm{B}=0$.

Overrange (OVR)
OVR goes high when $A-B$ is in phase with REF and larger than REF/2.

## Underrange (UNR)

UNR goes high when A-B is out of phase with REF and larger than REF/2.

## PRINCIPLE OF OPERATION

The AD2S93 is based on a Type 2 tracking closed-loop principle. The output tracks the position of the LVDT without the need for external convert and wait states. As the transducer moves through a position equivalent to the least significant bit weighting, the output is updated by one LSB. On the AD2S93, CLKOUT updates corresponding to one LSB increment. Figure 1 illustrates the principle of operation.


Figure 1. Functional Block Diagram

Because the conversion depends on the ratio of the input signals (ratiometric ac bridge), the AD2S93 is remarkably tolerant of input amplitude and frequency. This, combined with the definable Type 2 tracking closed-loop guarantees the AD2S93's repeatability for a given input. A phase sensitive detector, integrator and voltage controlled oscillator (VCO) form a closed loop system which seeks to null the output of the ACERROR. When this is accomplished the word state of the up/down counter equals within the rated accuracy of the converter, the LVDT position output.
For more information on the operation of the converter, see "Circuit Dynamics" section.

## DATA FORMAT

## OPERATING RANGE

The AD2S 93 operating range is defined in Figure 2. The linearity and specified operating range of the converter is the central two 12 -bit quadrants through zero. The corresponding input relationship is $-\mathrm{REF} / 2 \leq \mathrm{A}-\mathrm{B} \leq+\mathrm{REF} / 2$, ( $\pm$ is used to denote phase coherency). The sign bit is low for inputs with A-B in phase with REF. The two remaining 12-bit quadrants are used to denote over (OVR) and underrange (UNR). OVR goes high when A-B is in phase with REF and larger than REF/2. UNR goes high when A-B is out of phase with REF and larger than REF/2. LOS is an open drain output which pulls high when A and/or B are removed or REF is removed (see "Inbuilt Diagnostics"), or A + B is less than 100 mV .

## SCALING THE INPUTS

In order to match the LVDT output to the AD2S93 output, the inputs to the AD 2 S 93 need to be scaled. The operating range is illustrated in Figure 2. The AD2S 93 operates across $\pm 12$-bit range where the remaining 12 -bit quadrants are used to denote overrange and underrange. The output position word is a function of the ratio between $\mathrm{A}-\mathrm{B}$ and $\mathrm{V}_{\text {REF }}$ (see Figure 2) where:

$$
\pm F S R=\frac{(A-B)}{V_{R E F} / 2}
$$



Figure 2. Output Code Format

If the maximum operating stroke of an LVDT yielded a 1 V rms A-B output, the weighting of the LVDT to AD 2 S 93 digital output would be:

$$
\begin{gathered}
\frac{\text { Input Signal Full Scale }}{\text { Full-Scale Operating Range }\left( \pm 2^{12}\right)} \\
\frac{1 \times 2 \sqrt{2}}{2^{13}}
\end{gathered}
$$

Input Scaling $=345 \mu \mathrm{~V} / L S B$
This can be equated directly to the LVDT sensitivity specification in $\mathrm{mm} / \mathrm{v} / \mathrm{v}$.
Note: The overrange and underrange quadrants can be utilized by decoding the overrange and underrange MSBs and decoding the 12 magnitude bits. This will increase the operating range of the AD2S93 accordingly. However, if the input A-B $>\mathrm{V}_{\text {REF }}$ then the converter will lose track of the input and will only regain track when the input signal returns to within the operating range of the converter.

## INPUT GAIN

Since the transformation ratio of an LVDT or RVDT from excitation voltage to signal voltage can be $1: 0.15$, provision for gain scaling has been provided. The gain can, therefore, be selected to ensure that the full-scale output of converter represents the maximum stroke position of the transducer.
The gain setting is accomplished by connecting Pin 2, (DIFF) and Pin 3 (GAIN) together (unity gain) or connecting two resistors as shown in Figure 3.
The gain of the input stage is calculated using the following equation:

$$
\frac{\operatorname{DIFF}(A-B)}{(A-B) I N}=1+\frac{R_{3}}{R_{4}}
$$

e.g., For a gain of $5, \mathrm{R} 3=12 \mathrm{k} \Omega, \mathrm{R} 4=3 \mathrm{k} \Omega$

For a gain of $10, \mathrm{R} 3=18 \mathrm{k} \Omega, \mathrm{R} 4=2 \mathrm{k} \Omega$


Figure 3. Pre-Amp Gain Block

## SETTING THE CONVERTER BANDWIDTH

The AD2S93 bandwidth is set by placing three external components, $\mathrm{C} 1, \mathrm{C} 2$, and R 2 , around the integrator as illustrated by the figure below.


Figure 4. Integrator and VCO
Before the bandwidth can be set, the corresponding VCO gain setting must be determined. The VCO gain is directly related to the slew rate of the converter. This is set internally to two different rates defined internally by $\mathrm{R}_{\mathrm{v}}$.
Typical converter slew rates are defined below,

$$
\begin{aligned}
& G(1)=2400 \text { LSB/ms-Mode } 1 \\
& G(2)=800 \mathrm{LSB} / \mathrm{ms}-\text { Mode } 2
\end{aligned}
$$

Calculation of the component values for the bandwidth is detailed below. For more detailed information on component value selection for the AD2S93, please consult the "Passive Component Selection and Dynamic Modeling Software for the AD2S93 LVDT-to-Digital Converter."

## VCO Gain G (1) Mode 1

The available bandwidth with this option is from 0.5 kHz to 1.25 kHz .

$$
\begin{aligned}
& F_{\text {REF }}>8 \times F_{0} \\
& C 1=1 /\left(800 \times F o^{2}\right) \\
& C 2=8 \times C 1 \\
& R 2=45 \times F_{0}
\end{aligned}
$$

Where $\mathrm{F}_{\text {REF }}$ is the reference frequency, Fo is the closed-loop 3 dB point.
VCO Gain G (2) Mode 2
The available bandwidth with this option is from 45 Hz to 500 Hz .

$$
\begin{aligned}
& F_{R E F}>8 \times F o \\
& C 1=1 /\left(2400 \times F o^{2}\right) \\
& C 2=8 C 1 \\
& R 2=45 \times F o
\end{aligned}
$$

Where $\mathrm{F}_{\text {REF }}$ is the reference frequency, Fo is the closed-loop 3 dB point.

## INTERFACING TO THE AD2S93 (SEE "TIMING CHARACTERISTICS")

The absolute position information is extracted via a three-wire interface, DATA, CS and SCLK. The DATA output is held in a high impedance state when CS is high.
Upon the application of logic low to the CS pin, the DATA is enabled and the current position information is transferred from the counters to the serial interface. Data is retrieved by applying an external clock to the SCLK pin. The maximum data rate of the SCLK is 2 MHz . To ensure secure data retrieval, it is important to note that SCLK should not be applied until a minimum period of 600 ns after the application of logic low to CS. Data is then clocked out on successive positive edges of SCLK: 16 clock edges are required to extract the entire data word. Subsequent positive edges greater than the defined resolution of the converter will clock zeros from the data output if CS remains in a low state. The format of the data read is shown in Table I.

Table I.

|  | DB0 | DB1 | DB2 | DB3 | DATA DB4-D15 <br> MSB LSB |
| :--- | :--- | :--- | :--- | :--- | :--- |
| Function | LOS | OVR | UNR | SIGN | MAGNITUDE |

If less than the full 16 -bit word is required, then the data read can be terminated by releasing CS after the required number of bits have been read.

CS can be released a minimum of 100 ns after the last positive edge. If the user is reading data continuously, CS can be reapplied after a minimum of 600 ns after it is released. The minimum repetitive read time of the same converter is given by (16 bits read @ 2 MHz$)$. Min RD Time $=[600+(16 \times 500)+$ $600]=9.2 \mu \mathrm{~s}$.

## IN-BUILT DIAGNOSTICS

The first three bits read from the serial interface preceding the sign and magnitude data can be used to determine whether the data is valid or not. Over and underrange (OVR, UNR) denote the two extremes of the LVDT stroke where linearity of the LVDT may degrade. Loss of signal LOS is an open drain output which pulls high ( $12 \mathrm{k} \Omega$ pull up) when one of the following conditions is satisfied:

1. A and/or B is disconnected.
2. REF is disconnected.

Note: LOS has a response time of 50 ms max to the conditions stated above, see "Specifications."

## CONNECTING THE CONVERTER

Positive power supply $V_{D D}=+5 \mathrm{~V} \mathrm{dc} \pm 5 \%$ should be connected to Pin 17 and negative power supply $\mathrm{V}_{\mathrm{SS}}=-5 \mathrm{~V} \mathrm{dc} \pm 5 \%$ to Pin 16. Reversal of these power supplies will destroy this device. For LVDT connections to the converter please refer to Figures 5 through 7. On all connections, the maximum input reference signal $\mathrm{V}_{\mathrm{REF}}=2.0 \mathrm{~V} \mathrm{rms} \pm 10 \%$. To operate within the standard operating range, $\mathrm{A}-\mathrm{B}$ should not exceed $1.0 \mathrm{~V} \mathrm{rms} \pm 10 \%$. The AD2S93 AGND point is the point at which all analog signal grounds should be connected. Ground returns from the LVDT should be connected to AGND. The AD2S93 DGND pin should be connected to the AD2S 93 AGND pin. Ancillary Digital circuitry must be connected to the Star Point and not to the AD2S93 AGND pin.
In all cases, the AD 2 S 93 has been configured with the following dynamics.

$$
\begin{array}{ll}
\text { Reference Frequency } & 5 \mathrm{kHz} \\
3 \mathrm{~dB} \text { Bandwidth } & 625 \mathrm{~Hz}
\end{array}
$$

Vco Gain is set in MODE 1 where VCO GAIN is connected to VEL.

Using the procedure described in "setting the converter bandwidth" the following preferred values (E12 series) were calculated:

$$
\begin{aligned}
& C 1=3.3 n F \\
& C 2=27 n F \\
& R 2=27 k \Omega
\end{aligned}
$$

CALCULATING HF FILTER (C3, C4, R5, R6)

$$
15 \mathrm{k} \Omega \leq \mathrm{R} 5=\mathrm{R} 6 \leq 56 \mathrm{k} \Omega
$$

$$
C 3=C 4=\frac{1}{2 \pi R 5 F_{R E F}}
$$

So, $\mathrm{C} 3=1 \mathrm{nF}, \mathrm{R} 5=\mathrm{R} 6=33 \mathrm{k} \Omega, \mathrm{C} 4=1 \mathrm{nF}$ and in all cases $\mathrm{R} 7=15 \mathrm{k} \Omega$.

## Half-Bridge Type LVDT Connection

In this method of connection, it is necessary to add two additional bridge completion resistors $\mathrm{R}_{\mathrm{C}}$ and $\mathrm{R}_{\mathrm{C}}$, in order to derive a reference for the AD2S93. In selecting the bridge completion resistor, it is important to remember that mismatch between $\mathrm{R}_{\mathrm{Cl}}$ and $\mathrm{R}_{\mathrm{C} 2}$ will cause nonzero errors at null. If two LVDTs are being used for differential measurements, the resistors can be replaced by the second LVDT.

Three- or Four-Wire LVDT Connection
In this method of connection, shown in Figure 6, the converters digital output is proportional to the ratio:

$$
\frac{(A-B)}{(A+B) / 2}
$$

where A and B are the individual LVDT secondary output voltages. Inspection of Figure 6 should demonstrate why this relationship is true. (A-B) is simply the voltage across the series connected secondaries of the LVDT and is applied to the A, B input to the converter. $(\mathrm{A}+\mathrm{B}) / 2$ is effectively the average of the two secondary voltages as computed by the balanced bridge completion resistors and the grounding of the secondary center-tap.
Note: This method of connection is appropriate only for where ( $\mathrm{A}+\mathrm{B}$ ) is a constant, independent of LVDT position. Any lack of constancy in ( $\mathrm{A}+\mathrm{B}$ ) will be reflected as an additional non-
linearity in the output. It is up to the user to determine if (A + B) is sufficiently constant over the particular stroke length employed.
This method will usually restrict the usable LVDT range to half of its full range. The restriction can be eliminated, however, by attenuating DIFF by a factor of 2 or increasing $\mathrm{V}_{\text {REF }}$ by a factor of 2. This connection method has the tremendous advantage of being insensitive to temperature related phase shifts and excitation oscillator instability effects usually associated with more conventional LVDT conversion systems.
As in the case of the half-bridge type LVDT connection, $\mathrm{R}_{\mathrm{C} 1}$ and $\mathrm{R}_{\mathrm{C} 2}$ are the bridge completion resistors and are matched to a degree sufficient to ensure that the digital output representing the null position does not vary from the LVDT's natural null position. If null adjustment is required, a potentiometer can be used in place of the common connection between the two resistors.


Figure 5. Half-Bridge Type LVDT Connection


Figure 6. Three- or Four-Wire LVDT Connection

## Two-Wire LVDT Connection

This method should be used in cases where the sum of the LVDT secondary output voltages $(A+B)$ is not constant with LVDT displacement over the desired stroke length. This method of connection, shown in Figure 7, still maintains the ratiometric operation and the insensitivity to variations in reference amplitude and frequency. However, the phase shift between $V_{\text {REF }}$ and V1 should be minimized to maintain accuracy (see Section "PHASE SHIFT AND QUADRATURE EFFECTS"). Suggested phase compensation circuits are shown in Figure 7.

## PHASE SHIFT AND QUADRATURE EFFECTS

Reference to signal phase shift can be high in LVDTs, sometimes in the order of 70 degrees. If the converter is connected as in Figures 5 and 6, any effects due to this phase shift are minimized. This connection method, therefore, provides outstanding benefits.
The additional gain error caused by reference to signal phase shifts is given by:

$$
(1-\cos \theta) \times 100 \% \text { of } F S R
$$

where

$$
\theta=\text { phase shift between } V_{R E F} \text { and DIFF. }
$$

When the phase shift between $\mathrm{V}_{\mathrm{REF}}$ and V 1 is zero, additional quadrature on the signal will have no effect on the converter. This is another benefit of the conversion method. For example, when a REF lags (A-B) by approximately $10^{\circ}$, the gain error is approximately $1 \%$. When (A-B) lags REF by approximately $10^{\circ}$, the gain error is approximately $2 \%$.

## REMOTE MULTIPLE SENSOR INTERFACING

The DATA output of the AD2S93 is held in a high impedance state until $\overline{\mathrm{CS}}$ is taken LO. This allows a user to operate the AD 2 S 93 in an application with more than one converter connected on the same line. Figure 8 shows four LVDTs interfaced to four AD2S93s. Excitation for the LVDT is provided locally by an oscillator.
SCLK, DATA and two address lines are fed down low loss cables suitable for communication links. The two address lines are decoded locally into $\overline{\mathrm{CS}}$ for the individual converters. Data is received and transmitted using transmitters and receivers.


Figure 8. Remote Sensor Interface


Figure 7. Two-Wire LVDT Connection

## AD2S93

## CIRCUIT DYNAMICS/ERROR SOURCES <br> TRANSFER FUNCTION

The AD2S 93 operates as a Type 2 tracking servo loop. An integrator and VCO/counter perform the two integrations inherent in a Type 2 loop.
The overall system response of the AD 2 S 93 is that of a unity gain second order low-pass filter, with the position of the LVDT as the input and the digital position data as the output. Figure 9 illustrates the AD 2 S 93 system diagram.


Figure 9. AD2S93 Transfer Function
Note: The AD2S93 has been configured with the following dynamics.

| Reference Frequency | 10 kHz |
| :--- | :--- |
| 3 dB Bandwidth | 1250 Hz |

VCO Gain is set in MODE 1 where VCOGAIN is connected to VEL.
Using the procedure described in "SETTING THE CON-
VERTER BANDWIDTH," the following preferred values (E12 series) were calculated:

$$
\begin{aligned}
& C 1=820 \mathrm{pF} \\
& C 2=6.8 \mathrm{nF} \\
& R 2=56 \mathrm{k} \Omega
\end{aligned}
$$

$\mathrm{C} 3=\mathrm{C} 4=470 \mathrm{pF}, \mathrm{R} 7=15 \mathrm{k} \Omega, \mathrm{R} 5=\mathrm{R} 6=33 \mathrm{k} \Omega, \mathrm{C} 4=$ 470 pF
The open-loop transfer function is given by:

$$
\begin{array}{r}
G 1(s)=\frac{K_{1}}{s} \frac{1+s t_{1}}{1+s t_{2}} \\
G 2(s)=\frac{K_{2}}{s}
\end{array}
$$

where:

$$
\begin{aligned}
& t_{2}=R_{2}\left(\frac{C_{1} \times C_{2}}{C_{1}+C_{2}}\right) \\
& t_{1}=R_{2} C_{2}
\end{aligned}
$$

and:

$$
\begin{aligned}
& K_{1}=\frac{4 \times 10^{-3}}{25 \times 10^{3}}=160 \times 10^{-9} \times \frac{1}{C_{1}+C_{2}}=21 \\
& K_{2}=\frac{4}{R_{V} \times C_{V}}
\end{aligned}
$$

Note $A_{2}$ has two values depending on which mode is being used

$$
\begin{aligned}
& K_{2(M O D E 1)}=640 \times 10^{3} \\
& K_{2}(\text { MODE } 2)
\end{aligned}=160 \times 10^{3}
$$

The AD2S93 acceleration constant is given by:

$$
K_{a}=K_{1} \times K_{2}
$$

Therefore in the example given,

$$
K_{a}=K_{1} \times K_{2}=21 \times 640 \times 10^{3}=13.44 \times 10^{6} \mathrm{~s}^{-2}
$$

The AD2S93's design has been optimized with a critically damped response. The closed-loop transfer function is given by:

$$
\frac{\theta_{\text {OUT }}}{\theta_{I N}}=\frac{1+s t_{1}}{1+s t_{1}+\frac{s_{2}}{K_{1} K_{2}}+\frac{s_{3} t_{2}}{K_{1} K_{2}}} \frac{\theta_{\text {OUT }}}{\theta_{I N}}=\frac{K_{1} K_{2}}{s^{2}} \frac{\left(1+s t_{1}\right)}{1+s t_{2}}
$$

The normalized gain and phase diagrams are given in Figures 10 and 11 with a bandwidth of 1.25 kHz .


Figure 10. AD2S93 Gain Plot


Figure 11. AD2S93 Phase Plot

The small step response is given in Figure 12, and is the time taken for the converter to settled to within 1 LSB.

$$
t s=7 \mathrm{~ms}(14-b i t \text { resolution })
$$

The large step response (steps $>5 \%$ of FSR) applies when the error voltage will exceed the linear range of the converter. Typically it will take three times longer to reach the first peak FSR. In response to a velocity step [VELOUT/(d $\theta / \mathrm{dt})$ ] the velocity output will exhibit the same response characteristics as outlined above.


Figure 12. Small Step Response

## SOURCES OF ERROR

## ACCELERATION ERROR

A tracking converter employing a Type 2 servo loop does not suffer any velocity lag, however, there is an additional error due to acceleration. This additional error can be defined using the acceleration constant $K_{a}$ of the converter.

$$
K_{a}=\frac{\text { input acceleration }}{\text { position }}
$$

The numerator and denominator's units must be consistent. $K_{a}$ does not define maximum input acceleration, only the error due to its acceleration. The maximum acceleration allowable before the converter loses track is dependent on the positional accuracy requirement of the system.

$$
\text { Position Error } \times K_{a}=L S B / \mathrm{sec}^{2}
$$

$\mathrm{K}_{\mathrm{a}}$ can be used to predict the output position error for a given input acceleration. The AD2S93 in the example has a $\mathrm{K}_{\mathrm{a}}=13.44 \times 10^{6} \mathrm{sec}^{-2}$ if we apply an input accelerating at $100 \times 2^{14} \mathrm{LSB} / \mathrm{sec}^{2}$.

$$
\text { Error in } L S B s=\frac{\text { input acceleration }\left[L S B / \sec ^{2}\right]}{K_{a}\left[\sec ^{-2}\right]}
$$

$$
=\frac{100 \times 2^{14}}{13.44 \times 10^{6}}=0.12 \mathrm{LSBs}
$$

FEATURES

## Programmable Sinusoidal Oscillator

Synthesized Synchronous Reference Output
Programmable Output Frequency Range: $\mathbf{2 k H z - 2 0 ~ k H z}$
Wide Power Supply Range
"Loss-of-Signal" Indicator
20-Pin PLCC Package
Low Cost
APPLICATIONS
Primary Excitation of:
Resolvers
Synchros
LVDTs
RVDTs
Pressure Transducers
Load Cells
Inductosyns
AC Bridges

## GENERAL DESCRIPTION

The AD2S99 is a programmable sinusoidal oscillator available in a 20 -pin PLCC package, with an operating temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.
The AD2S99 provides a sine wave excitation output for resolvers and a wide variety of ac transducers. The AD2S99 also provides a synthesized reference output signal which is phase locked to the Sin and Cos inputs of the AD2S99. These inputs are provided by the secondary windings of a resolver. The synthesized reference eliminates the need for preset phase shift circuits and allows synchronous demodulation schemes such as type II tracking converters to be implemented without additional calibration of the total system.
By providing a Synchronous Reference output, the AD2S99 eliminates the temperature dependent phase shifts found with inductive transducers, and their resultant errors.

The AD2S99 requires only one external resistor for operation. The AD2S99 is manufactured on a $\mathrm{LC}^{2} \mathrm{MOS}$ process that combines high density, low power CMOS logic with bipolar linear circuitry.

FUNCTIONAL BLOCK DIAGRAM


## PRODUCT HIGHLIGHTS

Dynamic Phase Compensation
The AD2S99 dynamically compensates for any phase variation in the transducer by phase locking the outputs of the transducer to the synthesized reference output of the AD2S99.
Programmable Frequency
The oscillator frequency is easily programmed to $2 \mathrm{kHz}, 5 \mathrm{kHz}$, 10 kHz or 20 kHz by using the frequency select pins.
Loss of Signal Pin
The "LOS" output indicates a signal failure if both the sensor outputs feeding back to the AD2S99 are lost.

## Wide Power Supply Range

The AD2S 99 operates over the $\pm 5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$ power supply range.

This is a preliminary data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

AD2S99

| Parameter | Min Typ | Max | Units | Test Conditions |
| :---: | :---: | :---: | :---: | :---: |
|  | $\begin{aligned} & 2000 \\ & 5000 \\ & 10000 \\ & 20000 \end{aligned}$ |  | Hz <br> Hz <br> Hz <br> Hz | SEL1 SEL2 <br> $\mathrm{V}_{\text {SS }}$ $\mathrm{V}_{\text {SS }}$ <br> $\mathrm{V}_{\text {SS }}$ GND <br> GND $\mathrm{V}_{\text {SS }}$ <br> GND GND |
| ACCURACY <br> Frequency <br> Amplitude <br> Power Supply Rejection Ratio | $\begin{aligned} & \pm 3 \\ & \pm 3 \\ & 0.002 \end{aligned}$ | $\begin{aligned} & \pm 10 \\ & \pm 20 \\ & \pm 5 \\ & \pm 10 \\ & \pm 10 \\ & \pm 20 \\ & \pm 5 \\ & \pm 10 \end{aligned}$ |  | AP Grade @ $+25^{\circ} \mathrm{C}$ <br> AP Grade $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ <br> BP Grade @ $+25^{\circ} \mathrm{C}$ <br> BP Grade $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ <br> Output Variation as Function of Change in Power Supply Voltage |
| ```EXCITATION OUTPUT EXC, EXC SYNREF``` | $\begin{aligned} & 2 \\ & \pm 3 \end{aligned}$ |  |  | Square Wave $\begin{aligned} & \mathrm{R}_{\mathrm{LOAD}}=145 \Omega \text { to } \mathrm{GND} \\ & \mathrm{C}_{\mathrm{LOAD}}=1000 \mathrm{pF} \end{aligned}$ |
| OUTPUT DRIVE CAPABILITY <br> EXC, EXC <br> Current Drive <br> Capacitive Drive |  |  | $\begin{aligned} & \mathrm{mA} \mathrm{p}-\mathrm{p} \\ & \mathrm{~mA} \mathrm{p}-\mathrm{p} \\ & \mathrm{pF} \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{SS}}=-5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=+5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{SS}}=-15 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=+15 \mathrm{~V} \end{aligned}$ |
| PHASE LOCK RANGE <br> SIN Input to REF Output <br> Additional Phase Delay <br> AP Grade <br> BP Grade <br> LOS Detector Threshold |  |  | Degrees <br> Degrees <br> Degrees <br> V rms |  |
| ```TOTAL HARMONIC DISTORTION EXC, EXC AP Grade BP Grade``` |  | $\begin{aligned} & -25 \\ & -30 \end{aligned}$ | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \end{aligned}$ | $\begin{aligned} & \text { @ } 2 \mathrm{kHz} \\ & \mathrm{R}_{\text {LOAD }}=145 \Omega \text { to GND } \\ & \mathrm{C}_{\text {LOAD }}=1000 \mathrm{pF} \end{aligned}$ |
| FREQUENCY SELECT INPUTS SEL1, SEL2 ${ }^{1}$ | $\mathrm{V}_{\text {SS }}$ | AGND | V dc |  |
| ```LOS OUTPUT Output Low Voltage Output High Voltage``` | $\mathrm{V}_{\mathrm{DD}}-0.4$ | 0.4 | V dc <br> V dc | $\begin{aligned} & \mathrm{I}_{\mathrm{OL}}=400 \mu \mathrm{~A} \\ & 50 \mathrm{k} \Omega \text { Pull Up to } \mathrm{V}_{\mathrm{DD}} \text { (Open } \\ & \text { Drain Output) } \end{aligned}$ |
| POWER SUPPLIES <br> Supply Currents | $\begin{aligned} & +4.75 \\ & -4.75 \end{aligned}$ | $\begin{aligned} & +15.75 \\ & -15.75 \end{aligned}$ | V dc <br> V dc | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=+15.75 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=-15.75 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{DD}}=+4.75 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=-4.75 \mathrm{~V} \end{aligned}$ |
| TEMPERATURE RANGE | $\begin{aligned} & -40 \\ & -65 \end{aligned}$ | $\begin{aligned} & +85 \\ & +150 \end{aligned}$ | $\begin{aligned} & { }^{\circ} \mathrm{C} \\ & { }^{\circ} \mathrm{C} \end{aligned}$ | Operating <br> Storage |

## NOTES

${ }^{1}$ Frequency select pins SEL1 and SEL2 must be connected to appropriate voltage levels before power is applied.
Specifications subject to change without notice.

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

## RECOMMENDED OPERATING CONDITIONS

Power Supply Voltage $\left(\mathrm{V}_{\mathrm{DD}}\right.$ to $\left.\mathrm{V}_{\mathrm{SS}}\right) \ldots \ldots \pm 4.75 \mathrm{~V}$ to $\pm 15.75 \mathrm{~V}$
Analog Input Voltage (SIN and COS) $\ldots \ldots \ldots .2 \mathrm{~V}$ rms $\pm 10 \%$
Frequency Select (SEL1 and SEL2) $\ldots \ldots . . \mathrm{V}_{\text {SS }}$ to AGND
Operating Temperature Range $\ldots \ldots . . . .40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$

ABSOLUTE MAXIMUM RATINGS*
VDD ................................................. . . +16.5 V
V VS $_{\text {. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . }-16.5 \mathrm{~V}}$
Operating Temperature . . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Analog Input Voltages (SIN and COS) ......... V VS -0.3 V
. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . .to V VD +0.3 V
Frequency Select (SEL1, SEL2) . . . . . . . . . . . . . . VSS -0.4 V
. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . to AGND + 0.4 V
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ORDERING GUIDE

| Model | Temperature Range | Package Option |
| :--- | :---: | :--- |
| AD2S99?P | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{P}-20 \mathrm{~A}$ |

*For outline information see Package Information section.

PIN DESIGNATIONS

| Pin |  |  |
| :--- | :--- | :--- |
| No. | Mnemonic | Description |
| 1 | SEL2 | Frequency Select 2 |
| 2 | SEL1 | Frequency Select 1 |
| 3 | FBIAS | External Freq. Adjust Pin |
| 5 | SIN | Resolver Output SIN |
| $6^{\star}$ | DGND | Digital Ground |
| 7 | COS | Resolver Output COS |
| 10 | SYNREF | Synthesized Reference Output |
| 11 | LOS | Indicates When Both the SIN and |
| 12 | VDD | CoS Are Below the Threshold. |
| $16^{\star}$ | AGND | Positive Power Supply |
| 17 | EXC | Rnalog Ground |
| 18 | EXC | Resolver Reference (Plus) |
| $19^{\star}$ | Resolver Reference (Minus) |  |
| $20^{\star}$ | $V_{S S}$ | Negative Power Supply |

$\star$ Note: Pins 6 and 16 must be connected together and Pins 19 and 20 must be connected together.

PIN CONFIGURATION


NC = NO CONNECT

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD2S99 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


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FEATURES
Complete Vector Coordinate Transformation on Silicon
Mixed Signal Data Acquisition
Three-Phase $120^{\circ}$ and Orthogonal $90^{\circ}$ Signal
Transformation
Three-Phase Balance Diagnostic - Homopolar Output
APPLICATIONS

AC Induction and DC Permanent<br>Magnet Motor Control HVAC, Pump, Fan Control<br>Material Handling<br>Robotics<br>Spindle Drives<br>Gyroscopes<br>Dryers<br>Washing Machines<br>Electric Cars<br>Actuators<br>Three-Phase Power Measurement<br>Digital-to-Resolver \& Synchro Conversion

## GENERAL DESCRIPTION

The AD2S 100 performs the vector rotation of three phase 120 degree or two-phase 90 degree sine and cosine signals by transferring these inputs into a new reference frame which is controlled by the digital input angle $\phi$. Two transforms are included in the AD2S100. The first is the Clarke transform which computes the sine and cosine orthogonal components of a three phase input. These signals represent real and imaginary components which then form the input to the Park transform. The Park transform relates the angle of the input signals to a reference frame controlled by the digital input port. The digital input is a 12 -bit parallel binary representation.
If the input current signals are represented by Vds and Vqs, respectively, where Vds and Vqs are the real and imaginary components, then the transformation can be described as follows:

$$
\begin{aligned}
& \text { Vds }^{\prime}=\text { Vds } \operatorname{Cos} \phi-\text { Vqs } \operatorname{Sin} \phi \\
& \text { Vqs }^{\prime}=\text { Vds } \operatorname{Sin} \phi+\text { Vqs } \operatorname{Cos} \phi
\end{aligned}
$$

Where Vds' and Vqs' are the output of the Park transform and $\operatorname{Sin} \phi$, and $\operatorname{Cos} \phi$ are the values internally derived by the AD2S100 from the binary digital data.
The input section of the device can be configured to accept either three-phase inputs, two-phase inputs of a three-phase system, or two 90 degree input signals. The homopolar output detects the imbalance of a three-phase input only. Under normal conditions, this output will be zero.

FUNCTIONAL BLOCK DIAGRAM


The digital input section will accept a resolution of up to 12 bits (AD2S100). An input data strobe signal is required to synchronize the position data and load this information into the device counters. A busy output is provided to identify the conversion status of the AD2S100. The busy period represents the conversion time of the vector rotation.
Two analog output formats are available. A two-phase rotated output facilitates multiple rotation blocks. Three phase format signals are available for use with a PWM inverter.

## PRODUCT HIGHLIGHTS

## Hardware Peripheral for Standard Microcontrollers and DSP

 SystemsThe AD2S100 removes the time consuming cartesian transformations from digital processors and benchmarks a speed improvement of $30: 1$ on standard 20 MHz processors. AD2S100 transformation time $=2 \mu \mathrm{~s}$ (typ).
Field Orientated Control of AC and DC Brushless Motors
The AD2S100 accommodates all the necessary functions to provide a hardware solution for ac vector control of induction motors and dc brushless motors.

Three-Phase Imbalance Detection
The AD2S100 can be used to sense overcurrent situations or imbalances in a three-phase system via the homopolar output.

## Resolver to Digital Converter Interface

The AD2S100 provides general purpose interface for position sensors used in the application of dc brushless and ac induction motor control.

# AD2S100 <br> SPECIFICATIONS <br> $\left(V_{D D}=+5 V \pm 5 \% ; V_{S S}=-5 V \pm 5 \%\right.$ AGND $=D G N D=0 V ; T_{A}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ unless otherwise noted) 



| Parameter | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: |
| HOMOPOLAR OUTPUT HPOP-Output |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{OH}}$ | 4 |  |  | V dc | $\mathrm{I}_{\mathrm{OH}}=0.5 \mathrm{~mA}$ |
| $\mathrm{V}_{\mathrm{OL}}$ |  |  | 1 | V dc | $\mathrm{I}_{\mathrm{OL}}=0.5 \mathrm{~mA}$ |
| HPREF-REFERENCE |  | 0.5 |  | V dc | Homopolar Output-Internal |
|  |  |  |  |  | $I_{\text {source }}=25 \mu \mathrm{~A}$ and $20 \mathrm{k} \Omega$ to AGND |
| HPFILT-FILTER |  | 100 |  | k $\Omega$ | Internal Resistor with External Capacitor $=220 \mathrm{nF}$ |
| POWER SUPPLY |  |  |  |  |  |
| $\mathrm{V}_{\text {DD }}$ | 4.75 | 5 | 5.25 | $V \mathrm{dc}$ |  |
| $\mathrm{V}_{\text {ss }}$ | -5.25 | -5 | -4.75 | $V \mathrm{dc}$ |  |
| $\mathrm{I}_{\text {DD }}$ |  | 4 | 10 | mA | Quiescent Current |
| $\mathrm{I}_{\text {S }}$ |  | 4 | 10 | mA | Quiescent Current |

## NOTES

${ }^{1}$ Angular accuracy includes offsets and gain errors. Stationary digital input and maximum analog frequency inputs.
${ }^{2}$ Included in the angular error is an allowance for the additional error caused by the phase delay as a function of the input frequency. For example if
$\mathrm{f}_{\mathrm{INPUT}}=600 \mathrm{~Hz}$, the contribution to the error due to phase delay in $650 \mathrm{~ns} \times \mathrm{f}_{\mathrm{INPUT}} \times 60 \times 360=8.4$ arc minutes.
${ }^{3}$ Output subject to input voltage and gain.
Specifications in boldface are production tested.
Specifications subject to change without notice.

## RECOMMENDED OPERATING CONDITIONS

Power Supply Voltage ( $+\mathrm{V}_{\mathrm{DD}},-\mathrm{V}_{\mathrm{Ss}}$ ) $\ldots \ldots . . \pm 5 \mathrm{~V}$ dc $\pm 5 \%$
Analog Input Voltage (PH/IP1, 2, 3, 4) . . . . 2 V rms $\pm 10 \%$
Analog Input Voltage (PH/IPH1, 2, 3) . . . . . 3 V rms $\pm 10 \%$
Ambient Operating Temperature Range
Industrial (AP) . . . . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$

## ORDERING GUIDE

| Model | Temperature <br> Temperature Range | Accuracy | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD2S 100 AP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 18 arc min | P-44A |

* $\mathrm{P}=$ Plastic Leaded Chip Carrier. For outline information see Package Information section.

ABSOLUTE MAXIMUM RATINGS $\left(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right)$
$\mathrm{V}_{\mathrm{DD}}$ to AGND . . . . . . . . . . . . . . . . -0.3 V to +7 V dc $\mathrm{V}_{\text {ss }}$ to AGND . . . . . . . . . . . . . . . . . . . +0.3 V to -7 V dc AGND to DGND . . . . . . . . . . . . . . . . . . . . . . $\pm 0.3 \mathrm{~V}$ dc

Analog Input Voltage to AGND . . . . . . . . . . . . . V ${ }_{\text {ss }}$ to $\mathrm{V}_{\mathrm{DD}}$
Digital Input Voltage to DGND . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ dc
Digital Output Voltage to DGND . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ dc
Analog Output Voltage to AGND

Power Dissipation . . . . . . . . . . . . . . . . . . . . . . . . . 60 mW
Operating Temperature
Industrial (AP) $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 sec ) . . . . . . . . . . . $+300^{\circ} \mathrm{C}$

## CAUTION

1. Absolute Maximum Ratings are those values beyond which damage to the device may occur.
2. Correct polarity voltages must be maintained on the $+\mathrm{V}_{\mathrm{DD}}$ and $-V_{\text {Ss }}$ pins.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD2S100 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

PIN DESIGNATIONS

| Pin | Mnemonic | Description |
| :--- | :--- | :--- |
| 3 | STROBE | Start Conversion |
| 4 | V $_{\text {DD }}$ | Positive Power Supply |
| 5 | V Ss $^{2}$ | Negative Power Supply |
| 6 | PH/OP4 | Sin $(\theta+\phi)$ |
| 7 | PH/OP1 | Cos $(\theta+\phi)$ |
| 8 | PH/OP3 | Cos $\left(\theta+240^{\circ}+\phi\right)$ |
| 9 | PH/OP2 | Cos $\left(\theta+120^{\circ}+\phi\right)$ |
| 10 | AGND | Analog Ground |
| 11 | PH/IP4 | Sin $\theta$ Input |
| 12 | PH/IPH3 | High Level Cos $\left(\theta+240^{\circ}\right)$ Input |
| 13 | PH/IP3 | Cos $\left.\theta+240^{\circ}\right)$ Input |
| 14 | PH/IPH2 | High Level Cos $\left(\theta+120^{\circ}\right)$ Input |
| 15 | PH/IP2 | Cos ( $\left.\theta+120^{\circ}\right)$ Input |
| 16 | PH/IPH1 | High Level Cos $\theta$ Input |
| 17 | PH/IP1 | Cos $\theta)$ Input |
| 19 | VS | Negative Power Supply |
| 20 | HPREF | Homopolar Reference |
| 21 | HPOP | Homopolar Output |
| 22 | HPFILT | Homopolar Filter |
| 23 | CONV1 | Select Input Format $(3$ Phase/3 Wire, Sin $\theta$ |
| 24 | CONV2 | Cos $\theta /$ Input, 3 Phase/2 Wire $)$ |
| 25 | COS | Cos Output |
| 26 | SIN | Sin Output |
| 27 | DB12 | (DB1 = MSB DB12 = LSB |
| 38 | DB1 | Parallel Input Data) |
| 41 | VDD | Positive Power Supply |
| 42 | DGND | Digital Ground |
| 44 | BUSY | Conversion in Progress |

## NOTES

Signal Inputs PH/IP and PH/IPH on Pin Nos. 11 through 17.

1. $90^{\circ}$ orthogonal signals $=\operatorname{Sin} \theta, \operatorname{Cos} \theta($ Resolver $)=\mathrm{PH} / \mathrm{IP} 4$ and $\mathrm{PH} / \mathrm{IP} 1$.
2. Three phase, $120^{\circ}$, three wire signals
$=\operatorname{Cos} \theta, \operatorname{Cos}\left(\theta+120^{\circ}\right), \operatorname{Cos}\left(\theta+240^{\circ}\right)$.
$=\mathrm{PH} / \mathrm{IP} 1, \mathrm{PH} / \mathrm{IP} 2, \mathrm{PH} / \mathrm{IP} 3$
High Level $=\mathrm{PH} / \mathrm{IPH} 1, \mathrm{PH} / \mathrm{IPH} 2, \mathrm{PH} / \mathrm{IPH} 3$.
3. Three Phase, $120^{\circ}$, two wire signals $=\operatorname{Cos}\left(\theta+120^{\circ}\right), \operatorname{Cos}\left(\theta+240^{\circ}\right)=$ PH/IP2, PH/IP3.
In all cases where any of the input Pins 11 through 17 are not used, they must be left unconnected.

PIN CONFIGURATION


## THEORY OF OPERATION

A fundamental requirement for high quality induction motor drives is that the magnitude and position of the rotating air-gap rotor flux be known. This is normally carried out by measuring the rotor position via a position sensor and establishing a rotor reference frame that can be related to stator current coordinates.

To generate a flux component in the rotor, stator current is applied. A build-up of rotor flux is concluded which must be maintained by controlling the stator current, $\mathrm{i}_{\mathrm{ds}}$, parallel to the rotor flux. The rotor flux current component is the magnetizing current, $\mathrm{i}_{\mathrm{mr}}$.
Torque is generated by applying a current component which is perpendicular to the magnetizing current. This current is normally called the torque generating current, $\mathrm{i}_{\mathrm{qs}}$.
To orient and control both the torque and flux stator current vectors a coordinate transformation is carried out to establish a new reference frame related to the rotor. This complex calculation is carried out by the AD 2 S 100 vector processor.
To expand upon the vector operator a description of a single vector rotation is of assistance. If it is considered that the moduli of a vector is OP and that through the movement of rotor position by $\phi$, we require the new position of this vector it can be deduced as follows:
Let original vector $\mathrm{OP}=\mathrm{A}(\operatorname{Cos} \theta+\mathrm{jSIN} \theta)$ where $A$ is a constant;
so if, $O Q=O P \mathrm{e}^{\mathrm{j} \phi}$
and: $e^{j \phi}=\operatorname{Cos} \phi+j \operatorname{Sin} \phi$

$$
O Q=A(\operatorname{Cos}(\theta+\phi)+j \operatorname{Sin}(\theta+\phi))
$$

$=A[\operatorname{Cos} \theta \operatorname{Cos} \phi-\operatorname{Sin} \theta \operatorname{Sin} \phi+j \operatorname{Sin} \theta \operatorname{Cos} \phi+j \operatorname{Cos} \theta \operatorname{Sin} \phi]$

$$
\begin{equation*}
=A[(\operatorname{Cos} \theta+j \operatorname{Sin} \theta)(\operatorname{Cos} \phi+j \operatorname{Sin} \phi)] \tag{2}
\end{equation*}
$$



Figure 1. Vector Rotation in Polar Coordinate
The complex stator current vector can be represented as $i_{s}=i_{a s}+$ $a i_{b s}+a^{2} i_{c s}$ where $a=\mathrm{e} \frac{\mathrm{j} 2 \pi}{3}$ and $\mathrm{a}^{2}=\mathrm{e} \frac{\mathrm{j} 4 \pi}{3}$. This can be replaced by rectangular coordinates as

$$
\begin{equation*}
i_{s}=i_{d s}+j \ddot{i}_{q s} \tag{3}
\end{equation*}
$$

In this equation $i_{d s}$ and $i_{\text {qs }}$ represent the equivalent of a twophase stator winding which establishes the same magnitude of MMF in a three-phase system. These inputs can be seen after the three-phase to two-phase transformation in the AD2S100 block diagram. Equation (3) therefore represents a three-phase to two-phase conversion.

To relate these stator current to the moving reference frame the rotor currents assume the same rectangular coordinates, but are now rotated by the operator $e^{j \phi}$, where $e^{j \phi}=\operatorname{Cos} \phi+j \operatorname{Sin} \phi$.
Here the term vector rotator comes into play where the stator current vector can be represented in rotor-based coordinates or visa versa.
The AD2S100 uses $\mathrm{e}^{j \phi}$ as the core operator. Here $\phi$ represents the digital position angle which rotates as the rotor moves. In terms of the mathematical function, it rotates the orthogonal $i_{d s}$ and $\mathrm{i}_{\mathrm{qs}}$ components as follows:

$$
i_{d s}^{\prime}+j i_{q s^{\prime}}=\left(I_{d s}+j I_{q s}\right) e^{j \phi}
$$

where $i_{d s}{ }^{\prime}, i_{q s}{ }^{\prime}=$ stator currents in the rotor reference frame. And

$$
\begin{gathered}
e^{j \phi}=\operatorname{Cos} \phi+j \operatorname{Sin} \phi \\
=\left(I_{d s}+j I_{q s}\right)(\operatorname{Cos} \phi+j \operatorname{Sin} \phi)
\end{gathered}
$$

The output from the AD2S100 takes the form of:

$$
\begin{aligned}
& i_{d s^{\prime}}^{\prime}=I_{d s} \operatorname{Cos} \phi-I_{q s} \operatorname{Sin} \phi \\
& i_{q s^{\prime}}=I_{d s} \operatorname{Sin} \phi+I_{q s} \operatorname{Cos} \phi
\end{aligned}
$$

The matrix equation is:

$$
\left[\begin{array}{l}
i_{d s}{ }^{\prime} \\
i_{q s^{\prime}}
\end{array}\right]=\left[\begin{array}{rr}
\operatorname{Cos} \phi & -\operatorname{Sin} \phi \\
\operatorname{Sin} \phi & \operatorname{Cos} \phi
\end{array}\right]\left[\begin{array}{c}
I_{d s} \\
I_{q s}
\end{array}\right]
$$

and it is shown in Figure 2.


Figure 2. AD2S100 Vector Rotation Operation


Figure 3. Converter Operation Diagram

## CONVERTER OPERATION

The architecture of the AD2S100 is illustrated in Figure 3. The AD2S100 is configured in the forward transformation which rotates the rotor frame coordinates to the stator frame.

## Forward Rotation

In this configuration the $3 \phi-2 \phi$ Clark is bypassed, and inputs are fed directly into the quadrature ( $\mathrm{PH} / \mathrm{IP} 4$ ) and direct ( $\mathrm{PH} /$ IP1) inputs to the Park transform, $\mathrm{e}^{\mathrm{j} \phi}$, where $\phi$ is defined by the AD2S100's digital input. Position data, $\phi$, is loaded into the input latch on the positive edge of the strobe pulse. (For detail on the timing, please refer to the "timing diagram.") The negative edge of the strobe signifies that conversion has commenced. A busy pulse is subsequently produced as data is passed from the input latches to the Sin and $\operatorname{Cos}$ multipliers. During the loading of the multiplier, the busy pulse remains high to ensure simultaneous setting of $\phi$ in both the Sin and Cos registers.
The negative edge of the busy pulse signifies that the multipliers are set up and the orthogonal analog inputs are multiplied real time. The resultant two outputs are accessed via the PH/OP1 (Pin 7) and PH/OP4 (Pin 6), alternatively they can be directly applied to the output Clark transform. The Clark output is the vector sum of the analog input vector ( $\operatorname{Cos} \theta(\mathrm{PH} / \mathrm{OP} 1), \mathrm{Cos}$ $\left(\theta+120^{\circ}\right)(\mathrm{PH} / \mathrm{OP} 2), \operatorname{Cos}\left(\theta+240^{\circ}\right)(\mathrm{PH} / \mathrm{OP} 3)$ and the digital input vector $\phi$.
For other configurations, please refer to "Forward and Reverse Transformation."

## CONNECTING THE CONVERTER

## Power Supply Connection

The power supply voltages connected to $\mathrm{V}_{\mathrm{DD}}$ and $\mathrm{V}_{\text {Ss }}$ pins should be +5 V dc and -5 V dc and must not be reversed. Pin $4\left(\mathrm{~V}_{\mathrm{DD}}\right)$ and Pin $41\left(\mathrm{~V}_{\mathrm{DD}}\right)$ should both be connected to +5 V ; similarly, Pin $5\left(\mathrm{~V}_{\mathrm{SS}}\right)$ and Pin $19\left(\mathrm{~V}_{\mathrm{SS}}\right)$ should both be connected to -5 V dc.
It is recommended that decoupling capacitors, 100 nF (ceramic) and $10 \mu \mathrm{~F}$ (tantalum) or other high quality capacitors, are connected in parallel between the power line $\mathrm{V}_{\mathrm{DD}}, \mathrm{V}_{\mathrm{SS}}$ and AGND adjacent to the converter. Separate decoupling capacitors should be used for each converter. The connections are shown in Figure 4.


Figure 4. AD2S100 Power Supply Connection

## ANALOG SIGNAL INPUT AND OUTPUT CONNECTIONS

## Input Analog Signals

All analog signal inputs to AD2S100 are voltages. There are two different voltage levels of three-phase ( $0^{\circ}, 120^{\circ}, 240^{\circ}$ ) signal inputs. One is the nominal level, which is $\pm 2.8 \mathrm{~V}$ dc or 2 V rms and the corresponding input pins are $\mathrm{PH} / \mathrm{IP} 1$ ( Pin 17 ), $\mathrm{PH} / \mathrm{IP} 2$ (Pin 15), PH/IP3 (Pin 13) and PH/IP4 (Pin 11).
The high level inputs can accommodate voltages from nominal up to a maximum of $\pm \mathrm{V}_{\mathrm{DD}} / \mathrm{V}_{\mathrm{Ss}}$. The corresponding input pins are $\mathrm{PH} / \mathrm{IPH} 1$ (Pin 16), $\mathrm{PH} / \mathrm{IPH} 2$ (Pin 14) and $\mathrm{PH} / \mathrm{IPH} 3$ (Pin 12). The homopolar output can only be used in the three-phase connection mode.

The converter can accept both two-phase format and three-phase format input signals. For the two-phase format input, the two inputs must be orthogonal to each other. For the three-phase format input, there is the choice of using all three inputs or using two of the three inputs. In the latter case, the third input signal will be generated internally by using the information of other two inputs. The high level input mode, however, can only be selected with three-phase/three-input format. All these different conversion modes, including nominal/high input level and two/three-phase input format can be selected using two select pins (Pin 23, Pin 24). The functions are summarized in Table I.

Table I. Conversion Mode Selection

| Mode | Description | CONV1 <br> $($ Pin 23 $)$ | CONV2 <br> $($ Pin 24 $)$ |
| :--- | :--- | :--- | :--- |
| MODE1 | 2-Phase Orthogonal with 2 Inputs <br> Nominal Input Level | NC | DGND |
| MODE2 | 3-Phase $\left(0^{\circ}, 120^{\circ}, 240^{\circ}\right)$ with 3 Inputs <br> Nominal/High Input Level | DGND | $V_{D D}$ |
| MODE3 | 3-Phase $\left(0^{\circ}, 120^{\circ}, 240^{\circ}\right)$ with 2 Inputs <br> Nominal Input Level | $V_{D D}$ | $V_{D D}$ |

*The high level input mode can only be selected with MODE2.
MODE1: 2-Phase/2 Inputs with Nominal Input Level
In this mode, PH/IP1 and PH/IP4 are the inputs and the Pins 12 through 16 must be left unconnected.
MODE2: 3-Phase/3 Inputs with Nominal/High Input Level In this mode, either nominal or high level inputs can be used. For nominal level input operation, PH/IP1, PH/IP2 and PH/IP3 are the inputs, and there should be no connections to $\mathrm{PH} / \mathrm{IPH} 1$, $\mathrm{PH} / \mathrm{IPH} 2$ and $\mathrm{PH} / \mathrm{IPH} 3$; similarly, for high level input operation, the PH/IPH1, PH/IPH2 and PH/IPH3 are the inputs, and there should be no connections to $\mathrm{PH} / \mathrm{IP} 1, \mathrm{PH} / \mathrm{IP} 2$ and $\mathrm{PH} / \mathrm{IP} 3$. In both cases, the PH/IP4 should be left unconnected. For high level signal input operation, select MODE2 only.

## MODE3: 3-Phase/2 Inputs with Nominal Input Level

In this mode, $\mathrm{PH} / \mathrm{IP} 2$ and $\mathrm{PH} / \mathrm{IP} 3$ are the inputs and the third signal will be generated internally by using the information of other two inputs. It is recommended that $\mathrm{PH} / \mathrm{IP} 1, \mathrm{PH} / \mathrm{PH} 1$, $\mathrm{PH} / \mathrm{IPH} 2, \mathrm{PH} / \mathrm{IP} 4$ and $\mathrm{PH} / \mathrm{IPH} 3$ should be left unconnected.

## Output Analog Signals

There are three forms of analog output from the AD2S100.
$\mathrm{Sin} / \mathrm{Cos}$ orthogonal output signals are derived from the Clark/ three-to-two-phase conversion before the Park angle rotation. These signals are available on Pin $25(\operatorname{Cos} \theta)$ and $\operatorname{Pin} 26(\operatorname{Sin} \theta)$, and occur before Park angle rotation.

## Three-Phase Output Signals

$\left(\operatorname{Cos}(\theta+\phi), \operatorname{Cos}\left(\phi+\theta+120^{\circ}\right), \operatorname{Cos}\left(\phi+\theta+240^{\circ}\right)\right)$, where $\phi$ represents digital input angle. These signals are available on Pin 7 (PH/OP1), Pin 9 ( $\mathrm{PH} / \mathrm{OP} 2$ ) and Pin 8 ( $\mathrm{PH} / \mathrm{OP} 3$ ), respectively.
Two-Phase ( $\operatorname{Sin}(\theta+\phi)$, $\operatorname{Cos}(\theta+\phi))$ Signals
These represent the output of the coordinate transformation.
These signals are available on Pin 6 (PH/OP4, Sin $(\theta+\phi)$ ) and Pin 7 ( $\mathrm{PH} / \mathrm{OP} 1, \operatorname{Cos}(\theta+\phi)$ ).

## HOMOPOLAR OUTPUT

## Homopolar Reference

In a three-phase ac system, the sum of the three inputs to the converter can be used to indicate whether or not the phases are balanced.
If $\mathrm{V}_{\text {SUM }}=\mathrm{PH} / \mathrm{IP} 1+\mathrm{PH} / \mathrm{IP} 2+\mathrm{PH} / \mathrm{IP} 3$ (or $\mathrm{PH} / \mathrm{IPH} 1+$ $\mathrm{PH} / \mathrm{IPH} 2+\mathrm{PH} / \mathrm{IPH} 3)$ this can be rewritten as $\mathrm{V}_{\text {SUM }}=[\operatorname{Cos} \theta,+$ $\left.\operatorname{Cos}\left(\theta+120^{\circ}\right)+\operatorname{Cos}\left(\theta+240^{\circ}\right)\right]=0$. Any imbalances in the line will cause the sum $V_{\text {SUM }} \neq 0$. The AD2S100 homopolar output (HPOP) goes high when $\mathrm{V}_{\text {SUM }}>3 \times \mathrm{V}_{\text {ts }}$. The voltage level at which the HPOP indicates an imbalance is determined by the HPREF threshold, $\mathrm{V}_{\mathrm{ts}}$. This is set internally at $\pm 0.5 \mathrm{~V}$ dc ( $\pm 0.1 \mathrm{~V} \mathrm{dc}$ ). The HPOP goes high when

$$
V_{t s}<\frac{\left(\operatorname{Cos} \theta+\operatorname{Cos}\left(\theta+120^{\circ}\right)+\operatorname{Cos}\left(\theta+240^{\circ}\right)\right)}{3} \times V
$$

where V is the nominal input voltage.
With no external components $\mathrm{V}_{\text {SUM }}$ must exceed $\pm 1.5 \mathrm{~V}$ dc in order for HPOP to indicate an imbalance. The sensitivity of the threshold can be reduced by connecting an external resistor between HPOP and ground as shown in Figure 5, where,
$R_{E X T}=\Omega$

$$
V_{t s}=\frac{0.5 R_{E X T}}{R_{E X T}+20000}
$$

$V_{t s}=\mathrm{V}$ dc.


Figure 5. The Equivalent Homopolar Reference Input Circuitry

Example: From the equivalent circuit, it can be seen that the inclusion of a $20 \mathrm{k} \Omega$ resistor will reduce $\mathrm{V}_{\mathrm{ts}}$ to $\pm 0.25 \mathrm{~V}$ dc. This corresponds to an imbalance of $\pm 0.75 \mathrm{~V}$ dc in the inputs.

## Homopolar Filtering

The equation $\mathrm{V}_{\text {SUM }}=\operatorname{Cos} \theta+\operatorname{Cos}\left(\theta+120^{\circ}\right)+\operatorname{Cos}\left(\theta+240^{\circ}\right)$ $=0$ denotes an imbalance when $\mathrm{V}_{\text {SUM }} \neq 0$. There are conditions, however, when an actual imbalance will occur and the conditions as define by $\mathrm{V}_{\text {SUM }}$ will be valid. For example, if the first phase was open circuit when $\theta=90^{\circ}$ or $270^{\circ}$, the first phase is valid at 0 V dc. $\mathrm{V}_{\text {SUM }}$ is valid, therefore, when $\operatorname{Cos} \theta$ is close to 0 . In order to detect an imbalance $\theta$ has to move away from $90^{\circ}$ or $270^{\circ}$, i.e., when on a balanced line $\operatorname{Cos} \theta \neq 0$.
Line imbalance is detected as a function of HPREF, either set by the user or internally set at $\pm 0.5 \mathrm{~V} \mathrm{dc}$. This corresponds to a dead zone when $\phi=90^{\circ}$ or $270^{\circ} \pm 30^{\circ}$, i.e., $\mathrm{V}_{\text {SUM }}=0$, and, therefore, no indicated imbalance. If an external $20 \mathrm{k} \Omega$ resistor is added, this halves $\mathrm{V}_{\mathrm{ts}}$ and reduces the zone to $\pm 15^{\circ}$. Note this example only applies if the first phase is detached.

In order to prevent this false triggering an external capacitor needs to be placed from HPFILT to ground, as shown in Figure 5. This averages out the perceived imbalance over a complete cycle and will prevent the HPOP from alternatively indicating balance and imbalance over $\theta=0^{\circ}$ to $360^{\circ}$.
For

$$
\begin{array}{ll}
\frac{d \theta}{d t}=1000 \mathrm{rpm} & C_{E X T}=200 n F \\
\frac{d \theta}{d t}=100 \mathrm{rpm} & C_{E X T}=2.2 \mu F
\end{array}
$$

Note: The slower the input rotational speed, the larger the time constant required over which to average the HPOP output. Use of the homopolar output at slow rotational speeds becomes impractical with respect to the increased value for $\mathrm{C}_{\text {EXT }}$.


## TIMING DIAGRAMS

## Busy Output

The state of converter is indicated by the state of the BUSY output (Pin 44). The BUSY output will go HI at the negative edge of the STROBE input. This is used to synchronize digital input data and load the digital angular rotation information into the device counter. The BUSY output will remain HI for $2 \mu \mathrm{~s}$, and go LO until the next strobe negative edge occurs.

## Strobe Input

The width of the positive STROBE pulse should be at least 100 ns , in order to successfully start the conversion. The maximum frequency of STROBE input is 366 kHz , i.e., there should be at least $2.73 \mu \mathrm{~s}$ from the negative edge of one STROBE pulse to the next rising edge. This is illustrated by the following timing diagram and table.


Figure 7. AD2S100 Timing Diagram
Note: Digital data should be stable 25 ns before and after positive strobe edge.

Table II. AD2S100 Timing Table

| Parameter | Min | Typ | Max | Condition |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{1}$ | 100 ns <br> $1.7 \mu \mathrm{~s}$ | 30 ns | $2.5 \mu \mathrm{~s}$ | STROBE Pulse Width |
| $\mathrm{t}_{2}$ |  |  |  | STROBE $\downarrow$ to BUSY $\uparrow$ |
| $\mathrm{t}_{3}$ |  |  |  | BUSY Pulse Width |
| $\mathrm{t}_{4}$ |  | 100 ns |  | BUSY $\downarrow$ to STROBE $\uparrow$ |
| $\mathrm{t}_{\mathrm{r}}$ |  | 20 ns |  | BUSY Pulse Rise Time with No Load |
|  |  | 150 ns |  | BUSY Pulse Rise Time with 68 pF Load |
| $\mathrm{t}_{\mathrm{f}}$ |  | 10 ns |  | BUSY Pulse Fall Time with No Load |
|  |  | 120 ns |  | BUSY Pulse Fall Time with 68 pF Load |

## TYPICAL CIRCUIT CONFIGURATION

Figure 8 shows a typical circuit configuration for the AD2S100 in a three phase, nominal level input mode (MODE2).


Figure 8. Typical Circuit Configuration

## APPLICATIONS

## Forward and Reverse Transformation

The AD2S100 can perform both forward and reverse transformations. The section "Theory of Operation" explains how the chip operates with the core operator $\mathrm{e}^{+j \phi}$, which performs a forward transformation. The reverse transformation, $\mathrm{e}^{-\mathrm{j} \phi}$, is not mentioned in the above sections of the data sheet simply to avoid the confusion in the functionality and pinout. However, the reverse transformation is very useful in many different applications, and the AD2S100 can be easily configured in a reverse transformation configuration. Figure 9 shows four different phase input/output connections for AD2S100 reverse transformation operation.


Figure 9. Reverse Transformation Connections
$\sqrt{ }$ In Figure 9, "- $1^{\prime \prime}$ operator performs a $180^{\circ}$ phase shift operation. It can be illustrated by a 2 -phase-to-3-phase reverse transformation. An example is shown in Figure 10.


Figure 10. Two-Phase to Three-Phase Reverse Transformation

Field Oriented Control of AC Induction Machine in a Rotor Flux Frame
The architecture shown in Figure 11 identifies a simplified scheme where the AD2S100 permits the DSP computing core to execute the motor control in what is normally termed the rotor reference frame. This reference frame actually operates in synchronism with the rotor of a motor. This has significant benefits
regarding motor control efficiency and economics. The calculating power required in the rotor reference frame is significantly reduced because the currents and flux are rotating at the slip frequency. This permits calculations to be carried out in time frames of, $100 \mu \mathrm{~s}$, or under by a fixed-point DSP. Benchmark timing in this type of architecture can attain floating-point speed processing with a fixed-point processor. Perhaps the largest advantage is in the ease with which the rotor flux position can be obtained. A large amount of computation time is, therefore, removed by the AD2S100 vector processors due to the split architecture shown in Figure 11. Motor control systems employing one DSP to carry out the cartesian to polar transformations required for vector control are, therefore, tasked with additional duties due to the fact that they normally operate in the flux reference frame.

The robustness of the control system can also be increased by carrying out the control in the rotor reference frame. This is achieved through the ability to increase and improve both the algorithm quality in nonlinear calculations attributed to magnetizing inductance and rotor time constant for example. An increase in sampling time can also be concluded with this architecture by avoiding the additional computing associated with number truncation and rounding errors which reduce the signal to noise rejection ratio.


Figure 11. Rotor Reference Frame Architecture

## SIMPLE SLIP CONTROL

In an adjustable-frequency drive, the control strategy must ensure that motor operation is restricied to low slip frequencies, resulting in stable operation with a high power factor and a high torque per stator ampere. Figure 12 shows the block diagram of simple slip control using the AD2S100. Here, the slip frequency command $\omega_{2}$ and the current amplitude command are sent to the microprocessor to generate two orthogonal signals, $|\mathbf{I}| \operatorname{Sin} \theta$ and $|\mathbf{I}| \operatorname{Cos} \theta$ here $\left(\theta=\omega_{2}\right.$.) With the actual shaft position angle, $\phi$, (resolver-to-digital converter) and the orthogonal signals from


Figure 12. Slip Control of AC Induction Motor with AD2S100
the $\mu \mathrm{P}$, the AD2S100 generates the inverter frequency and amplitude command into a three-phase format. The three-phase sine wave reference currents are reproduced in the stator phases. For general applications, both the steady-state and dynamic performance of this simple control scheme is satisfactory. For detailed information about this application, please refer to the bibliography at the end of the data sheet.

## ADVANCED PMSM SERVO CONTROL

Electronically commutated permanent magnet synchronous motors (PMSM) are used in high performance drives for machine tools and robotics. When a field orientated control scheme is deployed, the resulting brushless drive has all the properties required for servo applications in machine tool fed drives, industrial robots, and spindle drives. These properties include large torque/inertia ratio, a high peak torque capability for fast acceleration and deceleration with high torsional stiffness at standstill.

Figure 13 shows the AD2S100 configured for both forward and reverse transformations. This architecture concludes both flux and torque current components independently. The additional control of Vd (flux component) allows for the implementation of field weakening schemes and maintenance of power factor.


Figure 13. PMSM Servo Control Using AD2S100

For more detailed information, please refer to the application note "Vector Control Using a Single Vector Rotation Semiconductor for Induction and Permanent Magnet Motors."

## MOTION CONTROL DSP COPROCESSOR

AC induction motors are superior to dc motors with respect to size/power ratio, weight, rotor inertia, maximum rotating velocity, efficiency and cost for motor ratings greater than 5 HP . However, because of nonlinear and the highly interactive multivariable control structure, ac induction motors have been considered difficult to control in applications demanding variable speed and torque.

Field orientated control theory and practice, under development since 1975, has offered the same level of control enjoyed by traditional dc machines. Practical implementation of these algorithms involves the use of DSP and microprocessor based architectures. The AD2S100 removes the needs for software implementation of the rotor-to-stator and stator-to-rotor transformations in the DSP or $\mu \mathrm{P}$. The reduction in throughput times from typically $100 \mu \mathrm{~s}(\mu \mathrm{P})$ and $40 \mu \mathrm{~s}$ (DSP) to $2 \mu \mathrm{~s}$ increases system bandwidths while also allowing additional features to be added to the CPU. The combination of the fixed point ADSP-2101 and the AD2S100, the "advanced motion control engine" shown in Figure 14, enables bandwidths previously attainable only through the use of floating point devices.
For more detailed information on the AD 2 S 100 vector control application and on this advanced motion control engine, please refer to application notes "Vector Control Using a Single Vector Rotation Semiconductor for Induction and Permanent Magnet Motors."

## MEASUREMENT OF HARMONICS

Three-phase ac power systems are widely used in power generation, transmission and electric drive. The quality of the electricity supply is affected by harmonics injected into the power main. In inverter fed ac machines, fluxes and currents of various frequencies are produced. Predominantly in ac machines the 5th and 7th harmonics are the most damaging; their reaction with the fundamental flux component produces 6th harmonic torque pulsations. The subsequent pulsating torque output may result in uneven motion of the motor, especially at low speeds.
The AD2S100 can be used to monitor and detect the presence and magnitude of a particular harmonic on a three-phase line. Figure 15 shows the implementation of such a scheme using the AD2S100. Note, the actual line voltages will have to be scaled before applying to the three-phase input of the AD2S100.
Selecting a harmonic is achieved by synchronizing the rotational frequency of the park digital input, $\phi$, with the frequency of the fundamental flux component and the integer harmonic selected. The update rate, $r$, of the counters is determined by:

$$
r=4096 \times \frac{n \times \omega}{2 \pi}
$$

Here, $r=$ input clock pulse rate (pulses/second);
$n=$ the order of harmonics to be measured;
$\omega=$ fundamental angular frequency of the ac signal.


Figure 14. Advanced Motion Control Engine

The magnitude of the $n$-th harmonic as well as the fundamental component in the power line is represented by the output of the low-pass filter, $a_{k}$. In concert with magnitude of the harmonic the AD2S100 homopolar output will indicate whether the three phases are balanced or not. For more details about this application, refer to the related application note listed in the bibliography.


Figure 15. Harmonics Measurement Using AD2S100

## MULTIPLE POLE MOTORS

For multi-pole motor applications where a single speed resolver is used, the AD2S100 input has to be configured to match the electrical cycle of the resolver with the phasing of the motor windings. The input to the AD2S100 is the output of a resolver-to-digital converter, e.g., AD2S80A series. The parallel output of the converter needs to be multiplied by $2^{n-1}$, where $n=$ the number of pole parts of the motor. In practice this is implemented by shifting the parallel output of the converter left relative to the number of pole pairs.
Figure 16 shows the generic configuration of the AD2S80A with the AD2S100 for a motor with n pole pairs. The MSB of the AD2S100 is connected to MSB-(n-1) bit of the AD2S80A digital output, MSB-1 bit to MSB-(n-2) bit, . . . , LSB bit to LSB bit of AD2S80A, etc.
Figure 17 shows the AD2S80A configured for use with a four pole motor, where $n=2$. Using the formula described the MSB is shifted left once.


12,14 OR 16-bit RESOLUTION MODE
Figure 16. A General Consideration in Connecting R/D Converter and AD2S100 for Multiple Pole Motors


Figure 17. Connecting of R/D Converter AD2S80A and AD2S100 for Four-Pole Motor Application

## DIGITAL-TO-RESOLVER AND SYNCHRO CONVERSION

The AD2S100 can be configured for use as a 12-bit digital-toresolver (DRC) or synchro converter (DSC). DRCs and DSCs are used to simulate the outputs of a resolver or a synchro. The simulated outputs are represented by the transforms outlined below.

## Resolver Outputs

$A \sin \omega \mathrm{t} \cdot \cos \phi$
$A \sin \omega \mathrm{t} \cdot \sin \phi$
Synchro Outputs
$A \sin \omega t \cdot \sin \phi$
$A \sin \omega t . \sin \left(\phi+120^{\circ}\right)$
$A \sin \omega t \cdot \sin \left(\phi+240^{\circ}\right)$
where: $A \sin \omega t=$ fixed ac reference
$\phi=$ digital input angle, i.e., shaft position
The waveforms are shown in Figures 18 and 19.


Figure 18. Electrical Representation and Typical Resolver Signals


Figure 19. Electrical Representation and Typical Synchro Signals

Configuring the AD2S100 for DRC and DSC operation is done by the following.
DRC-Must Select Mode 1

| Inputs | PH/IP4 | Pin 11 | AGND |
| :---: | :---: | :---: | :---: |
|  | PH/IP1 | Pin 17 | Reference Asin $\omega$ t |
| Outputs | PH/OP1 | Pin 7 |  |
|  | PH/OP4 | Pin 6 | Asin $\omega$ S $\operatorname{Sin} \phi$ |
| DSC-Must Select Mode 1 |  |  |  |
| Inputs | PH/IP4 | Pin 11 | Reference Asin $\omega$ t |
|  | PH/IP1 | Pin 17 | AGND |
| Outputs | PH/OP1 | Pin 7 | - Asin $\omega$ t $\operatorname{Sin} \phi$ |
|  | PH/OP2 | Pin 9 | $-A \sin \omega \mathrm{t} \operatorname{Sin}\left(\phi+120^{\circ}\right)$ |
|  | PH/OP3 | Pin 8 | $-A \sin \omega \mathrm{t} \operatorname{Sin}\left(\phi+240^{\circ}\right)$ |

NOTES

1. Valid information is only available after the strobe pulse and BUSY go low. For more information on DRCs see the AD2S65/AD2S66 data sheet.
2. To correct for inverse phasing of the DSC outputs the reference should be inverted, or the MSB can be inverted.

## APPLICATION NOTES LIST

1. "Vector Control Using a Single Vector Rotation Semiconductor for Induction and Permanent Magnet Motors," by F. P. Flett, Analog Devices.
2. "Gamana - DSP Vector Coprocessor for Brushless Motor Control," by Analog Devices and Infosys Manufacturing System.
3. "Silicon Control Algorithms for Brushless Permanent Magnet Synchronous Machines," by F. P. Flett.
4. "Single Chip Vector Rotation Blocks and Induction Motor Field Oriented Control," by A. P. M. Van den Bossche and P. J. M. Coussens.
5. "Three Phase Measurements with Vector Rotation Blocks in Mains and Motion Control," P. J. M. Coussens, et al.
6. "Digital to Synchro and Resolver Conversion with the AC Vector Processor AD2S100," by Dennis Fu.
7. "Experiment with the AD2S100 Evaluation Board," by Dennis Fu.

## FEATURES

Single Chip Solution, Contains Internal Oscillator and Voltage Reference<br>\section*{No Adjustments Required}<br>Insensitive to Transducer Null Voltage<br>Insensitive to Primary to Secondary Phase Shifts<br>DC Output Proportional to Position<br>20 Hz to $\mathbf{2 0} \mathbf{~ k H z}$ Frequency Range<br>Single or Dual Supply Operation<br>Unipolar or Bipolar Output<br>Will Operate a Remote LVDT at Up to 300 Feet<br>Position Output Can Drive Up to 1000 Feet of Cable<br>Will Also Interface to an RVDT<br>Outstanding Performance<br>Linearity: 0.05\% of FS max<br>Output Voltage: $\pm 11$ V min<br>Gain Drift: $50 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ of FS max<br>Offset Drift: $\mathbf{5 0} \mathbf{~ p p m} /{ }^{\circ} \mathrm{C}$ of FS max

## PRODUCT DESCRIPTION

The AD598 is a complete, monolithic Linear Variable Differential Transformer (LVDT) signal conditioning subsystem. It is used in conjunction with LVDTs to convert transducer mechanical position to a unipolar or bipolar dc voltage with a high degree of accuracy and repeatability. All circuit functions are included on the chip. With the addition of a few external passive components to set frequency and gain, the AD598 converts the raw LVDT secondary output to a scaled dc signal. The device can also be used with RVDT transducers.

The AD598 contains a low distortion sine wave oscillator to drive the LVDT primary. The LVDT secondary output consists of two sine waves that drive the AD598 directly. The AD598 operates upon the two signals, dividing their difference by their sum, producing a scaled unipolar or bipolar dc output.
The AD598 uses a unique ratiometric architecture (patent pending) to eliminate several of the disadvantages associated with traditional approaches to LVDT interfacing. The benefits of this new circuit are: no adjustments are necessary, transformer null voltage and primary to secondary phase shift does not affect system accuracy, temperature stability is improved, and transducer interchangeinterchangeabilityability is improved.
The AD598 is available in two performance grades:

| Grade | Temperature Range | Package |
| :--- | :--- | :--- |
| AD598JR | 0 to $+70^{\circ} \mathrm{C}$ | 20-Pin Small Outline (SOIC) |
| AD598AD | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 20-Pin Ceramic DIP |

It is also available processed to MIL-STD-883B, for the military range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.

## FUNCTIONAL BLOCK DIAGRAM



## PRODUCT HIGHLIGHTS

1. The AD598 offers a monolithic solution to LVDT and RVDT signal conditioning problems; few extra passive components are required to complete the conversion from mechanical position to dc voltage and no adjustments are required.
2. The AD598 can be used with many different types of LVDTs because the circuit accommodates a wide range of input and output voltages and frequencies; the AD598 can drive an LVDT primary with up to 24 V rms and accept secondary input levels as low as 100 mV rms.
3. The 20 Hz to 20 kHz LVDT excitation frequency is determined by a single external capacitor. The AD598 input signal need not be synchronous with the LVDT primary drive. This means that an external primary excitation, such as the 400 Hz power mains in aircraft, can be used.
4. The AD598 uses a ratiometric decoding scheme such that primary to secondary phase shifts and transducer null voltage have absolutely no effect on overall circuit performance.
5. Multiple LVDTs can be driven by a single AD598, either in series or parallel as long as power dissipation limits are not exceeded. The excitation output is thermally protected.
6. The AD598 may be used in telemetry applications or in hostile environments where the interface electronics may be remote from the LVDT. The AD598 can drive an LVDT at the end of 300 feet of cable, since the circuit is not affected by phase shifts or absolute signal magnitudes. The position output can drive as much as 1000 feet of cable.
7. The AD598 may be used as a loop integrator in the design of simple electromechanical servo loops.

AD598 - SDFGFIRMTINNS (typical @ $+25^{\circ} \mathrm{C}$ and $\pm 15 \mathrm{~V} d \mathrm{c}, \mathrm{C} 1=0.015 \mu \mathrm{~F}, \mathrm{R} 2=80 \mathrm{k} \Omega, \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$, unless otherwise noted. See Figure 7.)


## NOTES

${ }^{1} \mathrm{~V}_{\mathrm{A}}$ and $\mathrm{V}_{\mathrm{B}}$ represent the Mean Average Deviation (MAD) of the detected sine waves. Note that for this Transfer Function to linearly represent positive displacement, the sum of $V_{A}$ and $V_{B}$ of the LVDT must remain constant with stroke length. See "Theory of Operation." Also see Figures 7 and 12 for R2.
${ }^{2}$ From $T_{\min }$ to $T_{\max }$ the overall error due to the AD598 alone is determined by combining gain error, gain drift and offset drift. For example, the worst case overall error for the AD598AD from $T_{\min }$ to $T_{\text {max }}$ is calculated as follows: overall error = gain error at $+25^{\circ} \mathrm{C}\left( \pm 1 \%\right.$ full scale) + gain drift from $-40^{\circ} \mathrm{C}$ to $+25^{\circ} \mathrm{C}\left(50 \mathrm{ppm} /{ }^{\circ} \mathrm{C}\right.$ of $\left.\mathrm{FS} \times+65^{\circ} \mathrm{C}\right)+$ offset drift from $-40^{\circ} \mathrm{C}$ to $+25^{\circ} \mathrm{C}\left(50 \mathrm{ppm} /{ }^{\circ} \mathrm{C}\right.$ of $\left.\mathrm{FS} \times 65^{\circ} \mathrm{C}\right)= \pm 1.65 \%$ of full scale. Note that 1000 ppm of full scale equals $0.1 \%$ of full scale. Full scale is defined as the voltage difference between the maximum positive and maximum negative output.
${ }^{3}$ Nonlinearity of the AD598 only, in units of ppm of full scale. Nonlinearity is defined as the maximum measured deviation of the AD598 output voltage from a straight line. The straight line is determined by connecting the maximum produced full-scale negative voltage with the maximum produced full-scale positive voltage.
${ }^{4}$ See Transfer Function.
${ }^{5}$ This offset refers to the $\left(V_{A}-V_{B}\right) /\left(V_{A}+V_{B}\right)$ input spanning a full-scale range of $\pm$. [For $\left(V_{A}-V_{B}\right) /\left(V_{A}+V_{B}\right)$ to equal +1 , $V_{B}$ must equal zero volts; and correspondingly for $\left(\mathrm{V}_{\mathrm{A}}-\mathrm{V}_{\mathrm{B}}\right) /\left(\mathrm{V}_{\mathrm{A}}+\mathrm{V}_{\mathrm{B}}\right)$ to equal $-1, \mathrm{~V}_{\mathrm{A}}$ must equal zero volts. Note that offset errors do not allow accurate use of zero magnitude inputs; practical inputs are limited to 100 mV rms .] The $\pm 1$ span is a convenient reference point to define offset referred to input. For example, with this input span a value of $R 2=20 \mathrm{k} \Omega$ would give $\mathrm{V}_{\text {OUT }}$ span a value of $\pm 10$ volts. Caution, most LVDTs will typically exercise less of the $\left(\mathrm{V}_{\mathrm{A}}-\mathrm{V}_{\mathrm{B}}\right) /\left(\mathrm{V}_{\mathrm{A}}+\mathrm{V}_{\mathrm{B}}\right)$ input span and thus require a larger value of R2 to produce the $\pm 10 \mathrm{~V}$ output span. In this case the offset is correspondingly magnified when referred to the output voltage. For example, a Schaevitz E100 LVDT requires $80.2 \mathrm{k} \Omega$ for R2 to produce a $\pm 10.69 \mathrm{~V}$ output and $\left(\mathrm{V}_{\mathrm{A}}-\mathrm{V}_{\mathrm{B}}\right) /\left(\mathrm{V}_{\mathrm{A}}+\mathrm{V}_{\mathrm{B}}\right)$ equals 0.27 . This ratio may be determined from the graph shown in Figure $18,\left(\mathrm{~V}_{\mathrm{A}}-\mathrm{V}_{\mathrm{B}}\right) /\left(\mathrm{V}_{\mathrm{A}}+\mathrm{V}_{\mathrm{B}}\right)=(1.71 \mathrm{~V} \mathrm{rms}-0.99 \mathrm{~V} \mathrm{rms}) /(1.71 \mathrm{~V} \mathrm{rms}+0.99 \mathrm{~V} \mathrm{rms})$. The maximum offset value referred to the $\pm 10.69 \mathrm{~V}$ output may be determined by multiplying the maximum value shown in the data sheet $( \pm 1 \%$ of FS by $1 / 0.27$ which equals $\pm 3.7 \%$ maximum. Similarly, to determine the maximum values of offset drift, offset CMRR and offset PSRR when referred to the $\pm 10.69 \mathrm{~V}$ output, these data sheet values should also be multiplied by ( $1 / 0.27$ ). For this example, for the AD598AD the maximum values of offset drift, PSRR offset and CMRR offset would be: $185 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ of FS; $741 \mathrm{ppm} / \mathrm{V}$ and $741 \mathrm{ppm} / \mathrm{V}$ respectively when referred to the $\pm 10.69 \mathrm{~V}$ output.
${ }^{6}$ For example, if the excitation to the primary changes by 1 dB , the gain of the system will change by typically 100 ppm .
${ }^{7}$ Output ripple is a function of the AD598 bandwidth determined by C2, C3 and C4. See Figures 16 and 17 .
${ }^{8}$ R1 is shown in Figures 7 and 12.
${ }^{9}$ Excitation voltage drift is not an important specification because of the ratiometric operation of the AD598.
${ }^{10}$ For outline information see Package Information section.
Specifications subject to change without notice.
Specifications shown in boldface are tested on all production units at final electrical test. Results from those tested are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.

## THERMAL CHARACTERISTICS

|  | $\boldsymbol{\theta}_{\mathbf{J C}}$ | $\boldsymbol{\theta}_{\mathbf{J A}}$ |
| :--- | :--- | :--- |
| SOIC Package | $22^{\circ} \mathrm{C} / \mathrm{W}$ | $80^{\circ} \mathrm{C} / \mathrm{W}$ |
| Side Brazed Package | $25^{\circ} \mathrm{C} / \mathrm{W}$ | $85^{\circ} \mathrm{C} / \mathrm{W}$ |

## ABSOLUTE MAXIMUM RATINGS



CONNECTION DIAGRAM
Plastic SOIC (R) Package
and
Side Brazed Ceramic DIP (D) Package

| $-v_{s} \square$ |  | $20+v_{s}$ |
| :---: | :---: | :---: |
| Exc 12 |  | 19 OFFSET 1 |
| ExC 23 |  | 18 OfFSET 2 |
| Level 14 |  | 17 Signal reference |
| level 25 | AD598 | 16 signal output |
| frea 16 | TOP VIEW (Not to Scale) | 15] feedback |
| freq 27 |  | 14 Output filter |
| b1 filter 8 |  | 13 A1 Fllter |
| b2 fitter 9 |  | 12 A 2 FILTER |
| $v_{8} 10$ |  | (1) $\mathrm{v}_{\mathrm{A}}$ |

## AD598

## THEORY OF OPERATION

A block diagram of the AD598 along with an LVDT (Linear Variable Differential Transformer) connected to its input is shown in Figure 5. The LVDT is an electromechanical transducer whose input is the mechanical displacement of a core and whose output is a pair of ac voltages proportional to core position. The transducer consists of a primary winding energized by an external sine wave reference source, two secondary windings connected in series, and the moveable core to couple flux between the primary and secondary windings.


Figure 5. AD598 Functional Block Diagram
The AD598 energizes the LVDT primary, senses the LVDT secondary output voltages and produces a dc output voltage proportional to core position. The AD598 consists of a sine wave oscillator and power amplifier to drive the primary, a decoder which determines the ratio of the difference between the LVDT secondary voltages divided by their sum, a filter and an output amplifier.
The oscillator comprises a multivibrator which produces a triwave output. The triwave drives a sine shaper, which produces a low distortion sine wave whose frequency is determined by a single capacitor. Output frequency can range from 20 Hz to 20 kHz and amplitude from 2 V rms to 24 V rms . Total harmonic distortion is typically -50 dB .
The output from the LVDT secondaries consists of a pair of sine waves whose amplitude difference, $\left(\mathrm{V}_{\mathrm{A}}-\mathrm{V}_{\mathrm{B}}\right)$, is proportional to core position. Previous LVDT conditioners synchronously detect this amplitude difference and convert its absolute value to a voltage proportional to position. This technique uses the primary excitation voltage as a phase reference to determine the
polarity of the output voltage. There are a number of problems associated with this technique such as (1) producing a constant amplitude, constant frequency excitation signal, (2) compensating for LVDT primary to secondary phase shifts, and (3) compensating for these shifts as a function of temperature and frequency.
The AD598 eliminates all of these problems. The AD598 does not require a constant amplitude because it works on the ratio of the difference and sum of the LVDT output signals. A constant frequency signal is not necessary because the inputs are rectified and only the sine wave carrier magnitude is processed. There is no sensitivity to phase shift between the primary excitation and the LVDT outputs because synchronous detection is not employed. The ratiometric principle upon which the AD598 operates requires that the sum of the LVDT secondary voltages remains constant with LVDT stroke length. Although LVDT manufacturers generally do not specify the relationship between $\mathrm{V}_{\mathrm{A}}+\mathrm{V}_{\mathrm{B}}$ and stroke length, it is recognized that some LVDTs do not meet this requirement. In these cases a nonlinearity will result. However, the majority of available LVDTs do in fact meet these requirements.
The AD598 utilizes a special decoder circuit. Referring to the block diagram and Figure 6 below, an implicit analog computing loop is employed. After rectification, the A and B signals are multiplied by complementary duty cycle signals, d and (1-d) respectively. The difference of these processed signals is integrated and sampled by a comparator. It is the output of this comparator that defines the original duty cycle, $d$, which is fed back to the multipliers.
As shown in Figure 2, the input to the integrator is $[(A+B) d]$ $B$. Since the integrator input is forced to 0 , the duty cycle $d=B /(A+B)$.
The output comparator which produces $d=B /(A+B)$ also controls an output amplifier driven by a reference current. Duty cycle signals $d$ and ( $1-\mathrm{d}$ ) perform separate modulations on the reference current as shown in Figure 6, which are summed. The summed current, which is the output current, is $\mathrm{I}_{\text {REF }} \times(1-2 \mathrm{~d})$. Since $d \stackrel{=}{=} /(A+B)$, by substitution the output current equals $\mathrm{I}_{\text {REF }} \times(\mathrm{A}-\mathrm{B}) /(\mathrm{A}+\mathrm{B})$. This output current is then filtered and converted to a voltage since it is forced to flow through the scaling resistor R2 such that:

$$
V_{O U T}=I_{R E F} \times(A-B) /(A+B) \times R 2
$$



Figure 6. Block Diagram of Decoder

## FEATURES

Single Chip Solution, Contains Internal Oscillator and
Voltage Reference
No Adjustments Required
Interfaces to Half-Bridge LVDT, 4-Wire LVDT
DC Output Proportional to Position
$\mathbf{2 0 ~ H z}$ to $\mathbf{2 0} \mathbf{~ k H z}$ Frequency Range
Unipolar or Bipolar Output
Will Also Implement AC Bridge
Outstanding Performance
Linearity: 0.05\%
Output Voltage: $\pm 11 \mathrm{~V}$
Gain Drift: 20 ppm/ ${ }^{\circ} \mathrm{C}$ (typ)
Offset Drift: 5 ppm/ ${ }^{\circ} \mathrm{C}$ (typ)

## PRODUCT DESCRIPTION

The AD698 is a complete, monolithic Linear Variable Differential Transformer (LVDT) signal conditioning subsystem. It is used in conjunction with LVDTs to convert transducer mechanical position to a unipolar or bipolar dc voltage with a high degree of accuracy and repeatability. All circuit functions are included on the chip. With the addition of a few external passive components to set frequency and gain, the AD698 converts the raw LVDT output to a scaled dc signal. The device will operate with half-bridge LVDTs, LVDTs connected in the series opposed configuration, (4-wire), RVDTs.
The AD698 contains a low distortion sine wave oscillator to drive the LVDT primary. Two synchronous demodulation channels of the AD698 are used to detect primary and secondary amplitude. The part divides the output of the secondary by the amplitude of the primary and multiplies by a scale factor. This eliminates scale factor errors due to drift in the amplitude of the primary drive, improving temperature performance and stability.

The AD698 uses a unique ratiometric architecture to eliminate several of the disadvantages associated with traditional approaches to LVDT interfacing. The benefits of this new circuit are: no adjustments are necessary; temperature stability is improved; and transducer interchangeability is improved.
The AD698 is available in two performance grades:

| Grade | Temperature Range | Package |
| :--- | :--- | :--- |
| AD698AP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 28-Pin PLCC |
| AD698SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 24-Pin Cerdip |



## PRODUCT HIGHLIGHTS

1. The AD698 offers a single chip solution to LVDT signal conditioning problems. All active circuits are on the monolithic chip with only passive components required to complete the conversion from mechanical position to dc voltage.
2. The AD698 can be used with many different types of position sensors. The circuit is optimized for use with any LVDT, including half-bridge and series opposed, (4 wire) configurations. The AD698 accommodates a wide range of input and output voltages and frequencies.
3. The 20 Hz to 20 kHz excitation frequency is determined by a single external capacitor. The AD698 provides up to 24 volts rms to differentially drive the LVDT primary, and the AD698 meets its specifications with secondary input levels as low as 100 millivolts rms.
4. Change in oscillator amplitude with temperature will not affect overall circuit performance. The AD698 computes the ratio of the secondary voltage to the primary voltage to determine position and direction. No adjustments are required.
5. Multiple LVDTs can be driven by a single AD698 either in series or parallel as long as power dissipation limits are not exceeded. The excitation output is thermally protected.
6. The AD698 may be used as a loop integrator in the design of simple electromechanical servo loops.
7. The sum of the secondaries' voltages do not need to be constant.

AD698

\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Parameter} \& \multicolumn{3}{|c|}{AD698SQ} \& \multicolumn{3}{|c|}{AD698AP} \& \multirow[b]{2}{*}{Unit} \\
\hline \& Min \& Typ \& Max \& Min \& Ty \& Max \& \\
\hline TRANSFER FUNCTION \({ }^{1}\) \& \multicolumn{6}{|c|}{\(V_{\text {OUT }}=\frac{A}{B} \times 500 \mu A \times R 2\)} \& V \\
\hline OVERALL ERROR \(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) \& \& 0.4 \& 1.65 \& \& 0.4 \& 1.65 \& \% of FS \\
\hline \begin{tabular}{l}
SIGNAL OUTPUT CHARACTERISTICS \\
Output Voltage Range \\
Output Current, \(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) \\
Short Circuit Current \\
Nonlinearity \({ }^{2} \mathrm{~T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) \\
Gain Error \({ }^{3}\) \\
Gain Drift \\
Output Offset \\
Offset Drift \\
Excitation Voltage Rejection \({ }^{4}\) \\
Power Supply Rejection ( \(\pm 12 \mathrm{~V}\) to \(\pm 18 \mathrm{~V}\) ) \\
PSRR Gain \\
PSRR Offset \\
Common-Mode Rejection ( \(\pm 3 \mathrm{~V}\) ) \\
CMRR Gain \\
CMRR Offset \\
Output Ripple \({ }^{5}\)
\end{tabular} \& \(\pm 11\) \& \begin{tabular}{l}
11 \\
20 \\
75 \\
0.1 \\
20 \\
0.02 \\
5 \\
100 \\
50 \\
15 \\
25 \\
2 \\
4
\end{tabular} \& \[
\begin{aligned}
\& \pm 500 \\
\& \pm 1.0 \\
\& \pm 100 \\
\& \pm 1 \\
\& \pm 25 \\
\& \\
\& 300 \\
\& 100 \\
\& \\
\& 100 \\
\& 100
\end{aligned}
\] \& \(\pm 11\) \& \[
\begin{aligned}
\& 11 \\
\& 20 \\
\& 75 \\
\& 0.1 \\
\& 20 \\
\& 0.02 \\
\& 5 \\
\& 100 \\
\& \\
\& 50 \\
\& 15 \\
\& 25 \\
\& 2 \\
\& 4
\end{aligned}
\] \& \[
\begin{aligned}
\& \pm 500 \\
\& \pm 1.0 \\
\& \pm 100 \\
\& \pm 1 \\
\& \pm 25 \\
\& \\
\& 300 \\
\& 100 \\
\& \\
\& 100 \\
\& 100
\end{aligned}
\] \& \begin{tabular}{l}
V \\
mA \\
mA \\
ppm of FS \\
\(\%\) of FS. \\
\(\mathrm{ppm} /{ }^{\circ} \mathrm{C}\) of FS \\
\% of FS \\
\(\mathrm{ppm} /{ }^{\circ} \mathrm{C}\) of FS \\
ppm/dB \\
ppm/V \\
ppm/V \\
ppm/V \\
ppm/V \\
mV rms
\end{tabular} \\
\hline \begin{tabular}{l}
EXCITATION OUTPUT CHARACTERISTICS (@ 2.5 kHz ) \\
Excitation Voltage Range \\
Excitation Voltage (Resistors Are 1\% Absolute Values)
\[
\begin{aligned}
\& \left(\mathrm{R} 1=\mathrm{Open}^{6}{ }^{6}\right. \\
\& (\mathrm{R} 1=12.7 \mathrm{k} \Omega) \\
\& (\mathrm{R} 1=487 \Omega)
\end{aligned}
\] \\
Excitation Voltage TC \({ }^{7}\) \\
Output Current \\
\(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) \\
Short Circuit Current \\
DC Offset Voltage (Differential, R1 \(=12.7 \mathrm{k} \Omega\) ) \\
\(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\) \\
Frequency \\
Frequency TC \\
Total Harmonic Distortion
\end{tabular} \& \begin{tabular}{l}
2.1 \\
1.2 \\
2.6 \\
14 \\
30 \\
20
\end{tabular} \& 100
50
40
60
30
200
-50 \& \[
\begin{aligned}
\& \pm 100 \\
\& 20 \mathrm{k}
\end{aligned}
\] \& \begin{tabular}{l}
2.1 \\
1.2 \\
2.6 \\
14 \\
30 \\
20
\end{tabular} \& \[
\begin{aligned}
\& 100 \\
\& 50 \\
\& 40 \\
\& 60 \\
\& 30 \\
\& \\
\& 200 \\
\& -50
\end{aligned}
\] \& \[
\begin{aligned}
\& 24 \\
\& 2.15 \\
\& 4.35 \\
\& 21.2 \\
\& \\
\& \\
\& \\
\& \pm 100 \\
\& 20 \mathrm{k}
\end{aligned}
\] \& \begin{tabular}{l}
V rms \\
V rms \\
V rms \\
V rms ppm \(/{ }^{\circ} \mathrm{C}\) mA rms mA rms mA \\
mV \\
Hz \\
\(\mathrm{ppm} /{ }^{\circ} \mathrm{C}\) \\
dB
\end{tabular} \\
\hline \begin{tabular}{l}
SIGNAL INPUT CHARACTERISTICS \\
A/B Ratio Usable Full-Scale Range \\
Signal Voltage B Channel Signal Voltage A Channel Input Impedance Input Bias Current (BIN, AIN) Signal Reference Bias Current Excitation Frequency
\end{tabular} \& \[
\begin{aligned}
\& 0.1 \\
\& 0.1 \\
\& 0.0
\end{aligned}
\] \& 200
1
2 \& \[
\begin{aligned}
\& 0.9 \\
\& 3.5 \\
\& 3.5 \\
\& \\
\& 5 \\
\& 10 \\
\& 20 \mathrm{k}
\end{aligned}
\] \& \[
\begin{aligned}
\& 0.1 \\
\& 0.1 \\
\& 0.0
\end{aligned}
\]
\[
0
\] \& \[
\begin{aligned}
\& 200 \\
\& 1 \\
\& 2
\end{aligned}
\] \& \[
\begin{aligned}
\& 0.9 \\
\& 3.5 \\
\& 3.5 \\
\& \\
\& 5 \\
\& 10 \\
\& 20 \mathrm{k} \\
\& \hline
\end{aligned}
\] \& \begin{tabular}{l}
V rms \\
V rms \(\mathrm{k} \Omega\) \\
\(\mu \mathrm{A}\) \\
\(\mu \mathrm{A}\) \\
Hz
\end{tabular} \\
\hline \begin{tabular}{l}
POWER SUPPLY REQUIREMENTS \\
Operating Range \\
Dual Supply Operation ( \(\pm 10\) V Output) \\
Single Supply Operation \\
0 V to +10 V Output \\
0 V to -10 V Output \\
Current (No Load at Signal and Excitation Outputs) \\
\(\mathrm{T}_{\text {MIN }}\) to \(\mathrm{T}_{\text {MAX }}\)
\end{tabular} \& \[
\begin{aligned}
\& 13 \\
\& \pm 13 \\
\& \\
\& 17.5 \\
\& 17.5
\end{aligned}
\] \& 12 \& 36

15

18 \& $$
\begin{aligned}
& 13 \\
& \pm 13 \\
& \\
& 17.5 \\
& 17.5
\end{aligned}
$$ \& 12 \& 36

15

18 \& | V V |
| :--- |
| V |
| V |
| mA |
| mA | <br>

\hline OPERATING TEMPERATURE RANGE \& -55 \& \& +125 \& -40 \& \& +85 \& ${ }^{\circ} \mathrm{C}$ <br>
\hline
\end{tabular}

## NOTES

${ }^{1} A$ and $B$ represent the Mean Average Deviation (MAD) of the detected sine waves $V_{A}$ and $V_{B}$. The polarity of $V_{\text {OUT }}$ is affected by the sign of the $A$ comparator, i.e., multiply $\mathrm{V}_{\text {OUT }} \times+1$ for $\mathrm{A}_{\text {COMP }+}>\mathrm{A}_{\text {COMP- }}$, and $\mathrm{V}_{\text {OUT }} \times-1$ for $\mathrm{A}_{\text {COMP }-}>\mathrm{A}_{\text {COMP }+}$.
${ }^{2}$ Nonlinearity of the AD698 only in units of ppm of full scale. Nonlinearity is defined as the maximum measured deviation of the AD698 output voltage from a straight line. The straight line is determined by connecting the maximum produced full-scale negative voltage with the maximum produced full-scale positive voltage.
${ }^{3}$ See Transfer Function.
${ }^{4}$ For example, if the excitation to the primary changes by 1 dB , the gain of the system will change by typically 100 ppm .
${ }^{5}$ Output ripple is a function of the AD698 bandwidth determined by C 1 and C 2 . A 1000 pF capacitor should be in parallel with R 2 to reduce the output ripple. See Figures 7 and 13.
${ }^{6} \mathrm{R} 1$ is shown in Figures 7 and 13.
${ }^{7}$ Excitation voltage drift is not an important specification because of the ratiometric operation of the AD698.
${ }^{8}$ From $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ the overall error due to the AD698 alone is determined by combining gain error, gain drift and offset drift. For example, the typical overall error for the AD698AP from $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ is calculated as follows: Overall Error $=$ Gain Error at $25^{\circ} \mathrm{C}\left( \pm 0.2 \%\right.$ Full Scale) + Gain Drift from $-40^{\circ} \mathrm{C}$ to $25^{\circ} \mathrm{C}\left(20 \mathrm{ppm} /{ }^{\circ} \mathrm{C} \times 65^{\circ} \mathrm{C}\right)+$ Offset Drift from $-40^{\circ} \mathrm{C}$ to $25^{\circ} \mathrm{C}\left(5 \mathrm{ppm} /{ }^{\circ} \mathrm{C} \times 65^{\circ} \mathrm{C}\right)= \pm 0.36 \%$ of full scale. Note that 1000 ppm of full scale equals $0.1 \%$ of full scale.
Specifications subject to change without notice.
Specifications shown in boldface are tested on all production units at final electrical test. Results from those tested are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.

## ABSOLUTE MAXIMUM RATINGS

Total Supply Voltage ( $+\mathrm{V}_{\mathrm{S}}$ to $-\mathrm{V}_{\mathrm{s}}$ ) . . . . . . . . . . . . . 36 V
Storage Temperature Range
P Package . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Q Package . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

Q Package . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Operating Temperature Range

| AD698SQ . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  |
| :---: | :---: |
| AD698AP | - $40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Lead Temperature Range (Soldering 60 sec ) |  |
| Power Dissipation Derates above $+65^{\circ} \mathrm{C}$ |  |
| P Package | $2 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ |
| Q Package | $12 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ |

THERMAL CHARACTERISTICS

|  | $\boldsymbol{\theta}_{\mathbf{J C}}$ | $\boldsymbol{\theta}_{\mathbf{J A}}$ |
| :--- | :--- | :--- |
| P Package | $30^{\circ} \mathrm{C} / \mathrm{W}$ | $60^{\circ} \mathrm{C} / \mathrm{W}$ |
| Q Package | $26^{\circ} \mathrm{C} / \mathrm{W}$ | $62^{\circ} \mathrm{C} / \mathrm{W}$ |

ORDERING GUIDE

| Model | Package Description | Package Option $^{\star}$ |
| :--- | :--- | :--- |
| AD698AP | 28-Pin PLCC | P-28A |
| AD698SQ | 24-Pin Double Cerdip | Q-24A |

*For outline information see Package Information section.

## CONNECTION DIAGRAMS

28-Pin PLCC


24-Pin Cerdip


## CAUTION



Typical Characteristics (at $+25^{\circ} \mathrm{Cand} \mathrm{v}_{\mathrm{s}}= \pm 15 \mathrm{~V}$ unless othewise noted)


Figure 1. Gain and Offset PSRR vs. Temperature


Figure 2. Gain and Offset CMRR vs. Temperature


Figure 3. Typical Gain Drift vs. Temperature


Figure 4. Typical Offset Drift vs. Temperature

## THEORY OF OPERATION

A block diagram of the AD698 along with an LVDT (linear variable differential transformer) connected to its input is shown in Figure 5 below. The LVDT is an electromechanical transducer-its input is the mechanical displacement of a core, and its output is an ac voltage proportional to core position. Two popular types of LVDTs are the half-bridge type and the series opposed or four-wire LVDT. In both types the moveable core couples flux between the windings. The series-opposed connected LVDT transducer consists of a primary winding energized by an external sine wave reference source and two secondary windings connected in the series opposed configuration. The output voltage across the series secondary increases as the core is moved from the center. The direction of movement is detected by measuring the phase of the output. Half-bridge LVDTs have a single coil with a center tap and work like an autotransformer. The excitation voltage is applied across the coil; the voltage at the center tap is proportional to position. The device behaves very similar to a resistive voltage divider.


Figure 5. Functional Block Diagram
The AD698 energizes the LVDT coil, senses the LVDT output voltages and produces a dc output voltage proportional to core position. The AD698 has a sine wave oscillator and power amplifier to drive the LVDT. Two synchronous demodulation stages are available for decoding the primary and secondary voltages. A decoder determines the ratio of the output signal voltage to the input drive voltage, (A/B). A filter stage and output amplifier are used to scale the resulting output.
The oscillator comprises a multivibrator which produces a triwave output. The triwave drives a sine shaper which produces a low distortion sine wave. Frequency and amplitude are determined by a single resistor and capacitor. Output frequency can range from 20 Hz to 20 kHz and amplitude from 2 V to 24 V rms. Total harmonic distortion is typically -50 dB .
The AD698 decodes LVDTs by synchronously demodulating the amplitude modulated input (secondaries), A, and a fixed input reference (primary or sum of secondaries or fixed input), B. A common problem with earlier solutions was that any drift in the amplitude of the drive oscillator corresponds directly to a gain error in the output. The AD698, eliminates
these errors by calculating the ratio of the LVDT output to its input excitation in order to cancel out any drift effects. This device differs from the AD598 LVDT signal conditioner in that it implements a different circuit transfer function and does not require the sum of the LVDT secondaries $(A+B)$ to be constant with stroke length.

The AD698 block diagram is shown below. The inputs consist of two independent synchronous demodulation channels. The B channel is designed to monitor the drive excitation to the LVDT. The full wave rectified output is filtered by C2 and sent to the computational circuit. Channel A is identical except that the comparator is pinned out separately. Since the A channel may reach 0 V output at LVDT null, the A channel demodulator is usually triggered by the primary voltage, (B Channel). In addition, a phase compensation network may be required to add a phase lead or lag to the A Channel to compensate for the LVDT primary to secondary phase shift. For half-bridge circuits the phase shift is noncritical, and the A channel voltage is large enough to trigger the demodulator.


Figure 6. AD698 Block Diagram
Once both channels are demodulated and filtered a division circuit, implemented with a duty cycle multiplier, is used to calculate the ratio $\mathrm{A} / \mathrm{B}$. The output of the divider is a duty cycle. When $\mathrm{A} / \mathrm{B}$ is equal to 1 , the duty cycle will be equal to $100 \%$. (This signal can be used as is if a pulse width modulated output is required.) The duty cycle drives a circuit that modulates and filters a reference current proportional to the duty cycle. The output amplifier scales the $500 \mu \mathrm{~A}$ reference current converting it to a voltage. The output transfer function is thus,

$$
V_{O U T}=I_{R E F} \times A / B \times R 2, \text { where } I_{R E F}=500 \mu A
$$

## AD698

## CONNECTING THE AD698

The AD698 can easily be connected for dual or single supply operation as shown in Figures 7 and 13. The following general design procedures demonstrate how external component values are selected and can be used for any LVDT that meets AD698 input/output criteria. The connections for the A and B channels and the A channel comparators will depend on which transducer is used. In general follow the guidelines below.
Parameters set with external passive components include: excitation frequency and amplitude, AD698 input signal frequency, and the scale factor (V/inch). Additionally, there are optional features; offset null adjustment, filtering, and signal integration, which can be implemented by adding external components.


Figure 7. Interconnection Diagram for Half-Bridge LVDT and Dual Supply Operation

## DESIGN PROCEDURE

DUAL SUPPLY OPERATION
Figure 7 shows the connection method for half-bridge LVDTs. Figure 8 demonstrates the connections for 3- and 4-wire LVDTs connected in the series opposed configuration. Both examples use dual $\pm 15$ volt power supplies.

## A. Determine the Oscillator Frequency

Frequency is often determined by the required BW of the system. However, in some system the frequency is set to match the LVDT zero phase frequency as recommended by the manufacturer; in this case skip to Step 4.

1. Determine the mechanical bandwidth required for LVDT position measurement subsystem, $\mathrm{f}_{\text {SUbsystem }}$. For this example, assume $\mathrm{f}_{\text {SUBSYSTEM }}=250 \mathrm{~Hz}$.
2. Select minimum LVDT excitation frequency approximately $10 \times \mathrm{f}_{\text {Subsystem }}$. Therefore, let excitation frequency $=$ 2.5 kHz .
3. Select a suitable LVDT that will operate with an excitation frequency of 2.5 kHz . The Schaevitz E100, for instance, will operate over a range of 50 Hz to 10 kHz and is an eligible candidate for this example.
4. Select excitation frequency determining component Cl .
$C 1=35 \mu F H z / f_{\text {EXCITATION }}$


Figure 8. AD698 Interconnection Diagram for Series Opposed LVDT and Dual Supply Operation

## B. Determine the Oscillator Amplitude

Amplitude is set such that the primary signal is in the 1.0 V to 3.5 V rms range and the secondary signal is in the 0.25 V to 3.5 V rms range when the LVDT is at its mechanical full-scale position. This optimizes linearity and minimizes noise susceptibility. Since the part is ratiometric, the exact value of the excitation is relatively unimportant.
5. Determine optimum LVDT excitation voltage, $\mathrm{V}_{\text {EXC }}$. For a 4-wire LVDT determine the voltage transformation ratio, VTR, of the LVDT at its mechanical full scale. VTR = LVDT sensitivity $\times$ Maximum Stroke Length from null.
LVDT sensitivity is listed in the LVDT manufacturer's cata$\log$ and has units of volts output per volts input per inch displacement. The E100 has a sensitivity of $2.4 \mathrm{mV} / \mathrm{V} / \mathrm{mil}$. In the event that LVDT sensitivity is not given by the manufacturer, it can be computed. See section on determining LVDT sensitivity.

Multiply the primary excitation voltage by the VTR to get the expected secondary voltage at mechanical full scale. For example, for an LVDT with a sensitivity of $2.4 \mathrm{mV} / \mathrm{V} / \mathrm{mil}$ and a full scale of $\pm 0.1$ inch, the VTR $=0.0024 \mathrm{~V} / \mathrm{V} / \mathrm{Mil} \times$ $100 \mathrm{mil}=0.24$. Assuming the maximum excitation of 3.5 V rms, the maximum secondary voltage will be $3.5 \mathrm{~V} \mathrm{rms} \times$ $0.24=0.84 \mathrm{~V} \mathrm{rms}$, which is in the acceptable range.
Conversely the VTR may be measured explicitly. With the LVDT energized at its typical drive level $\mathrm{V}_{\mathrm{PRI}}$, as indicated by the manufacturer. Set the core displacement to its mechanical full-scale position and measure the output $\mathrm{V}_{\mathrm{SEC}}$ of the secondary. Compute the LVDT voltage transformation ratio, VTR. VTR $=\mathrm{V}_{\mathrm{SEC}} / \mathrm{V}_{\mathrm{PRI}}$. For the E100, $\mathrm{V}_{\mathrm{SEC}}=$ 0.72 V for $\mathrm{V}_{\mathrm{PRI}}=3 \mathrm{~V}$. $\mathrm{VTR}=0.24$.

For situations where LVDT sensitivity is low, or the mechanical FS is a small fraction of the total stroke length an input excitation of more than 3.5 V rms may be needed. In this case a voltage divider network may be placed across the LVDT primary to provide smaller voltage for the + BIN and -BIN input. If, for example, a network was added to divide the B Channel input by $1 / 2$ then the VTR should also be reduced by $1 / 2$ for the purpose of component selection.
Check the power supply voltages by verifying that the peak values of $\mathrm{V}_{\mathrm{A}}$ and $\mathrm{V}_{\mathrm{B}}$ are at least 2.5 volts less than the voltages at $+V_{S}$ and $-V_{S}$.
6. Referring to Figure 9, for $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}$, select the value of the amplitude determining component R1 as shown by the curve in Figure 9.


Figure 9. Excitation Voltage $V_{\text {EXC }}$ vs. R1
C. Choose the Filter Capacitors: C2, C3, C4
7. C2, C3 and C4 are a function of the desired bandwidth of the AD698 position measurement subsystem. They should be nominally equal values.

$$
C 2=C 3=C 4=10^{-4} \text { Farad Hz/f SUBSYSTEM }(H z)
$$

If the desired system bandwidth is 250 Hz , then

$$
C 2=C 3=C 4=10^{-4} \text { Farad } \mathrm{Hz} / 250 \mathrm{~Hz}=0.4 \mu F
$$

See Figures 14, 15 and 16 for more information about AD698 bandwidth and phase characterization.

## D. Set the Full-Scale Output Voltage

8. Compute R2, which sets the AD698 gain or full-scale output range, several pieces of information are needed:
a. LVDT sensitivity, S
b. Full-scale core displacement from null, d
$\mathrm{S} \times \mathrm{d}=\mathrm{VTR}$ and also equals the ratio $\mathrm{A} / \mathrm{B}$ at mechanical full scale. The VTR should be converted to units of V/V.
For a full-scale displacement of $d$ inches, voltage out of the AD698 is computed as

$$
V_{\text {OUT }}=S \times d \times 500 \mu A \times R 2
$$

$\mathrm{V}_{\text {OUT }}$ is measured with respect to the signal reference, Pin 17 shown in Figure 7.
Solving for R2,

$$
\begin{equation*}
R 2=\frac{V_{O U T}}{S \times d \times 500 \mu A} \tag{1}
\end{equation*}
$$

For $\mathrm{V}_{\text {OUt }}= \pm 10 \mathrm{~V}$ full-scale range, $(20 \mathrm{~V}$ span $)$ and d $= \pm 0.1$ inch full-scale displacement, ( 0.2 inch span)

$$
R 2=\frac{20 V}{2.4 \times 0.2 \times 500 \mu \mathrm{~A}}=83.3 \mathrm{k} \Omega
$$

$\mathrm{V}_{\text {OUT }}$ as a function of displacement for the above example is shown in Figure 10.


Figure 10. $V_{\text {Out }}( \pm 10$ V Full Scale) vs. Core Displacement ( $\pm 0.1$ Inch)

## E. Optional Offset of Output Voltage Swing

9. Selections of R3 and R4 permit a positive or negative output voltage offset adjustment.

$$
\begin{equation*}
V_{O S}=1.2 V \times R 2 \times\left(\frac{1}{R 3+2 k \Omega}-\frac{1}{R 4+2 k \Omega}\right) \tag{2}
\end{equation*}
$$

For no offset adjustment R3 and R4 should be open circuit.
To design a circuit producing a 0 V to +10 V output for a displacement of $\pm 0.1$ inch, set $\mathrm{V}_{\text {OUT }}$ to $+10 \mathrm{~V}, \mathrm{~d}=0.2$ inch and solve Equation (1) for R2.

$$
R 2=37.6 k \Omega
$$



Figure 11. Vout ( $\pm 5$ V Full Scale) vs. Core Displacement ( $\pm 0.1$ Inch)
This will produce a response shown in Figure 11.
In Equation (2) set $\mathrm{V}_{\mathrm{Os}}=5 \mathrm{~V}$ and solve for R3 and R4. Since a positive offset is desired, let R4 be open circuit. Rearranging Equation (2) and solving for R3

$$
R 3=\frac{1.2 \times R 2}{V_{O S}}-2 k \Omega=4.02 k \Omega
$$

Note that $\mathrm{V}_{\mathrm{OS}}$ should be chosen so that R 3 cannot have negative value.
Figure 12 shows the desired response.


Figure 12. $V_{\text {OUT }}$ ( 0 V-10 V Full Scale) vs. Displacement ( $\pm 0.1$ Inch)

## DESIGN PROCEDURE

SINGLE SUPPLY OPERATION
Figure 13 shows the single supply connection method.


Figure 13. Interconnection Diagram for Single Supply Operation

For single supply operation, repeat Steps 1 through 10 of the design procedure for dual supply operation. R5, R6 and C5 are additional component values to be determined. $\mathrm{V}_{\text {OUT }}$ is measured with respect to SIGNAL REFERENCE.
10. Compute a maximum value of R5 and R6 based upon the relationship

$$
R 5 \pm R 6 \leq V_{P S} / 100 \mu A
$$

11. The voltage drop across R 5 must be greater than

$$
2+10 k \Omega\left(\frac{1.2 V}{R 4+2 k \Omega}+250 \mu A+\frac{V_{\text {OUT }}}{4 \times R 2}\right) \text { Volts }
$$

Therefore

$$
R 5 \geq \frac{2+10 k \Omega\left(\frac{1.2 V}{R 4+2 k \Omega}+250 \mu A+\frac{V_{\text {OUT }}}{4 \times R 2}\right)}{100 \mu \mathrm{~A}} \text { Ohms }
$$

Based upon the constraints of R5 + R6 (Step 11) and R5
(Step 12), select an interim value of R6.
12. Load current through $R_{L}$ returns to the junction of R5 and R6, and flows back to $\mathrm{V}_{\mathrm{Ps}}$. Under maximum load conditions, make sure the voltage drop across R5 is met as defined in Step 11.
As a final check on the power supply voltages, verify that the peak values of $\mathrm{V}_{\mathrm{A}}$ and $\mathrm{V}_{\mathrm{B}}$ are at least 2.5 volts less than the voltages at $+V_{S}$ and $-V_{S}$.
13. C 5 is a bypass capacitor in the range of $0.1 \mu \mathrm{~F}$ to $1 \mu \mathrm{~F}$.

## Gain Phase Characteristics

To use an LVDT in a closed loop mechanical servo application, it is necessary to know the dynamic characteristics of the transducer and interface elements. The transducer itself is very quick to respond once the core is moved. The dynamics arise primarily from the interface electronics. Figures 14, 15 and 16 show the frequency response of the AD698 LVDT Signal Conditioner. Note that Figures 15 and 16 are basically the same; the difference is frequency range covered. Figure 15 shows a wider range of mechanical input frequencies at the expense of accuracy.


Figure 14. Gain and Phase Characteristics vs. Frequency (0 kHz-10 kHz)


Figure 15. Gain and Phase Characteristics vs. Frequency ( $0 \mathrm{kHz}-50 \mathrm{kHz}$ )


Figure 16. Gain and Phase Characteristics vs. Frequency ( $0 \mathrm{kHz}-10 \mathrm{kHz}$ )

Figure 16 shows a more limited frequency range with enhanced accuracy. The figures are transfer functions with the input to be considered as a sinusoidally varying mechanical position and the output as the voltage from the AD698; the units of the transfer function are volts per inch. The value of C2, C3, and C4, from Figure 7, are all equal and designated as a parameter in the figures. The response is approximately that of two real poles. However, there is appreciable excess phase at higher frequencies. An additional pole of filtering can be introduced with a shunt capacitor across R2, Figure 7; this will also increase phase lag.
When selecting values of $\mathrm{C} 2, \mathrm{C} 3$ and C 4 to set the bandwidth of the system, a trade-off is involved. There is ripple on the "dc" position output voltage, and the magnitude is determined by the filter capacitors. Generally, smaller capacitors will give higher system bandwidth and larger ripple. Figures 17 and 18 show the magnitude of ripple as a function of $\mathrm{C} 2, \mathrm{C} 3$ and C 4 , again all equal in value. Note also a shunt capacitor across R2, Figure 7 is shown as a parameter. The value of $R 2$ used was $81 \mathrm{k} \Omega$ with a Schaevitz E100 LVDT.


Figure 17. Output Voltage Ripple vs. Filter Capacitance


Figure 18. Output Voltage Ripple vs. Filter Capacitance

## Determining LVDT Sensitivity

LVDT sensitivity can be determined by measuring the LVDT secondary voltages as a function of primary drive and core position, and performing a simple computation.

Energize the LVDT at its recommended primary drive level, $\mathrm{V}_{\text {PRI }}$ ( 3 V rms for the E100). Set the core displacement to its mechanical full-scale position and measure secondary voltages $V_{A}$ and $V_{B}$.

$$
\text { Sensitivity }=\frac{V_{\text {SECONDARY }}}{V_{P R I} \times d}
$$

From Figure 19,

$$
\text { Sensitivity }=\frac{0.84}{3.5 V \times 100 \mathrm{mils}}=2.4 \mathrm{mV} / \mathrm{Vmil}
$$



Figure 19. LVDT Secondary Voltage vs. Core Displacement

## Thermal Shutdown and Loading Considerations.

The AD698 is protected by a thermal overload circuit. If the die temperature reaches $165^{\circ} \mathrm{C}$ the sine wave excitation amplitude gradually reduces, thereby lowering the internal power dissipation and temperature.
Due to the ratiometric operation of the decoder circuit, only small errors result from the reduction of the excitation amplitude. Under these conditions the signal-processing section of the AD698 continues to meet its output specifications

The thermal load depends upon the voltage and current delivered to the load as well as the power supply potentials. An LVDT Primary will present an inductive load to the sine wave excitation. The phase angle between the excitation voltage and current must also be considered, further complicating thermal calculations.

## APPLICATIONS

Most of the applications for the AD598 can also be implemented with the AD698. Please refer to the applications written for the AD598 for a detailed explanation.
See AD598 data sheet for:

- Proving Ring-Weigh Scale
- Synchronous Operation of Multiple LVDTs
- High Resolution Position-to-Frequency Circuit
- Low Cost Setpoint Controller
- Mechanical Follower Servo Loop
- Differential Gaging and Precision Differential Gaging


## AC BRIDGE SIGNAL CONDITIONER

Bridge circuits which use dc excitation are often plagued by errors caused by thermocouple effects, $1 / \mathrm{f}$ noise, dc drifts in the electronics, and line noise pickup. One way to get around these problems is to excite the bridge with an ac waveform, amplify the bridge output with an ac amplifier, and synchronously demodulate the resulting signal. The ac phase and amplitude information from the bridge is recovered as a dc signal at the output of the synchronous demodulator. The low frequency system noise, dc drifts, and demodulator noise all get mixed to the carrier frequency and can be removed by means of a low pass filter.
The AD698 with the addition of a simple ac gain stage can be used to implement an ac bridge. Figure 20 shows the connections for such a system. The AD698 oscillator provide ac excitation for the bridge. The low level bridge signal is amplified by the gain stage created by A1, A2 to provide a differential input to the A Channel of the AD698. The signal is then synchronously detected by A Channel. The B Channel is used to detect the level of the bridge excitation. The ratio of $A / B$ is then calculated and converted to an output voltage by R2. An optional phase lag/lead network can be added in front of the A comparator to adjust for phase delays through the bridge and the amplifier, or if the phase delay is small it can be ignored or compensated by a gain adjustment.
This circuit can be used for resistive bridges such as strain gages, or for inductive or capacitive bridges that are commonly used for pressure or flow sensors. The low level signal outputs of these sensors are susceptible to noise and interference and are good candidates for ac signal processing techniques.

## Component Selection

Amplifiers A1, A2 will be chosen depending on the type of bridge that is conditioned. Capacitive bridges should use an amplifier with low bias current; a large bleeder resistor will be required from the amplifier inputs to ground to provide a path for the dc bias current. Resistive and inductive bridges can use a more general purpose amplifier. The dc performance of A1, A2 are not as important as their ac performance. DC errors such as voltage offset will be chopped out by the AD698 since they are not synchronous to the carrier frequency.
The oscillator amplitude and span resistor for the AD698 may be chosen by first computing the transfer function or sensitivity of the bridge and the ac amplifier. This ratio will correspond to the A/B term in the AD698 transfer function. For example, suppose that a resistive strain gage with a sensitivity, S , of $2 \mathrm{mV} / \mathrm{V}$ at full scale is used. Select an arbitrary target value for $A / B$ that is close to its maximum value such as $\mathrm{A} / \mathrm{B}=0.8$. Then choose a gain for the ac amplifier so that the strain gage transfer function from excitation to output also equals 0.8 . Thus the required amplifier gain will be $[\mathrm{A} / \mathrm{B}] / \mathrm{S}$; or $0.8 / 0.002 \mathrm{~V} / \mathrm{V}=400$. Then select values for $\mathrm{R}_{\mathrm{S}}$ and $\mathrm{R}_{\mathrm{G}}$. For the gain stage:

$$
V_{O U T}=\left[\frac{2 \times R_{S}}{R_{G}+1}\right] \times V_{I N}
$$

Solving for $\mathrm{V}_{\text {OUT }} / \mathrm{V}_{\mathrm{IN}}=400$ and setting $\mathrm{R}_{\mathrm{G}}=100 \Omega$ then:

$$
R_{S}=[400-1] \times R_{G} / 2=19.95 \mathrm{k} \Omega
$$

Choose an oscillator amplitude that is in the range of 1 V to 3.5 V rms . For an input excitation level of 3 V rms the output signal from the amplifier gain stage will be $3.5 \mathrm{~V} \mathrm{rms} \times 0.8 \mathrm{~V}$ or 2.4 V rms , which is in the acceptable range.

Since $A / B$ is known, the value of R 2 , the output FS resistor may be chosen by the formula:

$$
V_{\text {OUT }}=A / B \times 500 \mu A \times R 2
$$

For a 10 V output at FS , with an $\mathrm{A} / \mathrm{B}$ of 0.8 ; solve for R 2 .

This will result in a $\mathrm{V}_{\text {OUt }}$ of 10 V for a full-scale signal from the bridge. The other components, C1, C2, C3, C4 may be selected by following the guidelines on general device operation mentioned earlier.

If a gain trim is required, then a trim resistor can be used to adjust either R 2 or $\mathrm{R}_{\mathrm{G}}$. Bridge offsets should be adjusted by a trim network on the OFFSET 1 and OFFSET 2 pins of the AD698.

$$
R 2=10 \mathrm{~V} /[0.8 \times 500 \mu \mathrm{~A}]=25.0 \mathrm{k} \Omega
$$



Figure 20. AD698 Interconnection Diagram for AC Bridge Applications
Selection Tree ..... 17-2
Selection Guides ..... 17-3
AD534 - Internally Trimmed Precision IC Multiplier ..... 17-5
AD633 - Low Cost Analog Multiplier ..... 17-9
AD734-10 MHz, 4-Quadrant Multiplier/Divider ..... 17-11
AD834-500 MHz Four-Quadrant Multiplier ..... 17-14
AD835-250 MHz, Voltage Output 4-Quadrant Multiplier ..... 17-17
MLT04 - Four-Channel, Four-Quadrant Analog Multiplier ..... 17-23

## Selection Tree - Multipliers and Dividers



## Selection Guides-Multipliers and Dividers

## Multipliers/Dividers

| Model | BW <br> MHz typ ${ }^{1}$ | Accuracy \% FS max | Supply Voltage | Output Voltage Swing | Package Options ${ }^{2}$ | Temp Ranges ${ }^{3}$ | Comments | Page ${ }^{4}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| AD834 | $>500$ | $\pm 2$ | +4V to $\pm 9 \mathrm{~V}$ |  | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | C, I, M/s | Very High Speed, 4-Quadrant Mult/Div | 17-14 |
| AD835 | 150 |  | $\pm 4.5 \mathrm{~V}$ to $\pm 5.5 \mathrm{~V}$ | $\pm 2$ | $\mathbf{N}, \mathbf{Q}, \mathbf{R}$ | I, M | High Speed Voltage Output, 4-Quadrant Multiplier | 17-17 |
| AD539 | 60 | $\pm 1.5-2.5$ | $\pm 4.5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$ |  | D, E, N | C, $\mathrm{M} / \mathrm{D}$ | High Speed, 2-Channel, 2-Quadrant Mult/Div | SL 2-27 |
| AD734 | 10 | $\pm 0.25-0.4$ | $\pm 8 \mathrm{~V}$ to $\pm 16.5 \mathrm{~V}$ | $\pm 12 \mathrm{~V}$ min | N, Q | I, M/ | Very High Accuracy Replacement for AD534 | 17-11 |
| AD633 | 1 | $\pm 2$ | $\pm 8 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | $\pm 11 \mathrm{~V}$ min | N, R | C | Low Cost, 4-Quadramt Multiplier | 17-9 |
| AD532 | 1 | $\pm 1-2$ | $\pm 10 \mathrm{~V}$ to $\pm 22 \mathrm{~V}$ | $\pm 10 \mathrm{~V}$ min | D, E, H | C, $\mathrm{M}_{\text {J }}$ | Accurate 4-Quadrant Mult/Div | SL 2-9 |
| AD632 | 1 | $\pm 0.5-1$ | $\pm 8 \mathrm{~V}$ to $\pm 22 \mathrm{~V}$ | $\pm 11 \mathrm{~V}$ min | D, H | I, M/s | High Accuracy Replacement for AD532 | SL 2-43 |
| AD534 | 1 | $\pm 0.25-1$ | $\pm 8 \mathrm{~V}$ to $\pm 22 \mathrm{~V}$ | $\pm 11 \mathrm{~V}$ min | D, E, H | C, $\mathrm{M}_{\text {Js }}$ | High Accuracy, 4-Quadrant Mult/Div | 17-5 |
| AD538 | 0.4 | $\pm 0.5-1$ | $\pm 4.5 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$ | $\pm 11 \mathrm{~V}$ | D | I, M/ | Simultaneous Mult/Div/Exponentiator | SL 2-23 |
| MLT04 | 8 | $\pm 1$ | $\pm 4.75$ to $\pm 5.25$ | $\pm 3.0$ | N, R | I | Quad, High Speed Multiplier for CRT Correction | 17-23 |

## Modulator/Demodulator

|  | Unity |  |  | Output |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Model |  | Gain | Slew Rate <br> V/ $\mu \mathrm{s}$ | Voltage Swing | Package Options ${ }^{2}$ | Temp Ranges ${ }^{3}$ | Comments |  |
| Model |  | Gain | V/rs | Swing | Options ${ }^{2}$ | Ranges ${ }^{3}$ | Comments | Page |
| AD630 | 2 | $\pm 1, \pm 2$ | 45 | $\pm 10 \mathrm{~V}$ min | D, E, N | C, I, M/ ${ }_{\text {D }}$ | Balanced Modulator/Demodulator with 10 V FS Output | SL 2-35 |

${ }^{1}$ Unity gain small signal bandwidth.



 temperature designator will be followed by: / to indicate 883B, ${ }_{\mathrm{J}}$ for JAN, ${ }_{\mathrm{D}}$ for SMD, and ${ }_{\mathrm{s}}$ for space level.
${ }^{4}$ SL $=$ Special Linear Reference Manual. All other entries refer to this volume.
Boldface Type: Data sheet information in this volume.

FEATURES
Pretrimmed to $\pm 0.25 \%$ max 4 -Quadrant Error (AD534L)
All Inputs ( $X, Y$ and $Z$ ) Differential, High Impedance for $\left[\left(X_{1}-X_{2}\right)\left(Y_{1}-Y_{2}\right) / 10 \mathrm{~V}\right]+Z_{2}$ Transfer Function
Scale-Factor Adjustable to Provide up to $\mathbf{X 1 0 0}$ Gain
Low Noise Design: $\mathbf{9 0} \mu \mathrm{V}$ rms, $\mathbf{1 0 H z}-10 \mathrm{kHz}$
Low Cost, Monolithic Construction
Excellent Long Term Stability
APPLICATIONS
High Quality Analog Signal Processing
Differential Ratio and Percentage Computations
Algebraic and Trigonometric Function Synthesis
Wideband, High-Crest rms-to-dc Conversion
Accurate Voltage Controlled Oscillators and Filters Available in Chip Form

## PRODUCT DESCRIPTION

The AD534 is a monolithic laser trimmed four-quadrant multiplier divider having accuracy specifications previously found only in expensive hybrid or modular products. A maximum multiplication error of $\pm 0.25 \%$ is guaranteed for the AD5 34L without any external trimming. Excellent supply rejection, low temperature coefficients and long term stability of the on-chip thin film resistors and buried zener reference preserve accuracy even under adverse conditions of use. It is the first multiplier to offer fully differential, high impedance operation on all inputs, including the Z -input, a feature which greatly increases its flexibility and ease of use. The scale factor is pretrimmed to the standard value of 10.00 V ; by means of an external resistor, this can be reduced to values as low as 3 V .
The wide spectrum of applications and the availability of several grades commend this multiplier as the first choice for all new designs. The AD5 34J ( $\pm 1 \%$ max error), AD534K ( $\pm 0.5 \%$ $\max$ ) and AD534L ( $\pm 0.25 \%$ max) are specified for operation over the 0 to $+70^{\circ} \mathrm{C}$ temperature range. The AD534S ( $\pm 1 \%$ max) and AD5 $34 \mathrm{~T}( \pm 0.5 \% \mathrm{max}$ ) are specified over the extended temperature range, $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. All grades are available in hermetically sealed TO-100 metal cans and TO-116 ceramic DIP packages. AD5 34J, K, S and T chips are also available.

FUNCTIONAL BLOCK DIAGRAM


## PROVIDES GAIN WITH LOW NOISE

The AD5 34 is the first general purpose multiplier capable of providing gains up to X 100 , frequently eliminating the need for separate instrumentation amplifiers to precondition the inputs. The AD534 can be very effectively employed as a variable gain differential input amplifier with high common mode rejection. The gain option is available in all modes, and will be found to simplify the implementation of many functionfitting algorithms such as those used to generate sine and tangent. The utility of this feature is enhanced by the inherent low noise of the AD534: $90 \mu \mathrm{~V}$, rms (depending on the gain), a factor of 10 lower than previous monolithic multipliers. Drift and feedthrough are also substantially reduced over earlier designs.

## UNPRECEDENTED FLEXIBILITY

The precise calibration and differential Z-input provide a degree of flexibility found in no other currently available multiplier. Standard MDSSR functions (multiplication, division, squaring, square-rooting) are easily implemented while the restriction to particular input/output polarities imposed by earlier designs has been eliminated. Signals may be summed into the output, with or without gain and with either a positive or negative sense. Many new modes based on implicit-function synthesis have been made possible, usually requiring only external passive components. The output can be in the form of a current, if desired, facilitating such operations as integration.

AD534-SPECIFICATIONS ${ }_{T_{1}=+25_{0}, \pm v_{1}=1 v_{1}, v_{2}=2(\alpha)}$


## NOTES

${ }^{1}$ Figures given are percent of full scale, $\pm 10 \mathrm{~V}$ (i.e., $0.01 \%=1 \mathrm{mV}$ ).
${ }^{2}$ May be reduced down to 3 V using external resistor between $-\mathrm{V}_{\mathrm{S}}$ and SF .
${ }^{3}$ Irreducible component due to nonlinearity: excludes effect of offsets.
${ }^{4}$ Using external resistor adjusted to give $\mathrm{SF}=3 \mathrm{~V}$.
${ }^{5}$ See functional block diagram for definition of sections.
Specifications subject to change without notice.

| Model | Min | $\begin{aligned} & \text { AD534: } \\ & \text { Typ } \end{aligned}$ | Max | Min | $\begin{aligned} & \text { AD534T } \\ & \text { Typ } \\ & \hline \end{aligned}$ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| MULTIPLIER PERFORMANCE <br> Transfer Function <br> Total Error ${ }^{1}(-10 \mathrm{~V} \leq \mathrm{X}, \mathrm{Y} \leq+10 \mathrm{~V})$ <br> $\mathrm{T}_{\mathrm{A}}=\min$ to $\max$ <br> Total Error vs Temperature <br> Scale Factor Error <br> $\left(\mathrm{SF}=10.000 \mathrm{~V}\right.$ Nominal) ${ }^{2}$ <br> Temperature-Coefficient of Scaling Voltage <br> Supply Rejection ( $\pm 15 \mathrm{~V} \pm 1 \mathrm{~V}$ ) <br> Nonlinearity, $X(X=20 \mathrm{~V}$ pk-pk, $\mathrm{Y}=10 \mathrm{~V})$ <br> Nonlinearity, $\mathrm{Y}(\mathrm{Y}=20 \mathrm{~V}$ pk-pk, $\mathrm{X}=10 \mathrm{~V})$ <br> Feedthrough ${ }^{3}$, X (Y Nuiled, $\mathrm{X}=20 \mathrm{~V}$ pk-pk 50 Hz ) <br> Feedthrough ${ }^{3}, \mathrm{Y}$ (X Nulled, $\mathrm{Y}=20 \mathrm{~V} \mathrm{pk}-\mathrm{pk} 50 \mathrm{~Hz}$ ) <br> Output Offset Voltage <br> Output Offset Voltage Drift |  | $\begin{aligned} & \frac{\left.X_{2}\right)\left(Y_{1}\right.}{10 \mathrm{~V}} \\ & \pm 0.2 \\ & \\ & \pm 0.0 \\ & \pm 0.0 \\ & \pm 0.4 \\ & \pm 0.2 \\ & \pm 0.3 \\ & \pm 0.0 \\ & \pm 5 \end{aligned}$ | $\begin{gathered} \left.\mathrm{f}_{2}\right) \\ +\mathrm{Z}_{2} \\ \pm \mathbf{1 . 0} \\ \pm 2.0 \\ \pm \mathbf{0 . 0 2} \end{gathered}$ |  | $\begin{aligned} & \frac{\left.X_{2}\right)\left(Y_{1}-\right.}{10 \mathrm{~V}} \\ & \pm 0.1 \\ & \\ & \pm 0.01 \\ & \pm 0.2 \\ & \pm 0.1 \\ & \pm 0.15 \\ & \pm 0.01 \\ & \pm 2 \end{aligned}$ | $\begin{aligned} & (2) \\ & \pm \mathrm{Z}_{2} \\ & \pm 0.5 \\ & \pm 1.0 \\ & \pm 0.01 \\ & \\ & \pm 0.005 \\ & \pm 0.3 \\ & \pm 0.1 \\ & \pm 0.3 \\ & \pm 0.1 \\ & \pm 15 \\ & \mathbf{3 0 0} \end{aligned}$ | \% <br> \% <br> \%/ ${ }^{\circ} \mathrm{C}$ <br> \% <br> $\%{ }^{\circ} \mathrm{C}$ <br> \% <br> \% <br> \% <br> \% <br> \% <br> mV <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| DYNAMICS <br> Small Signal BW, $\left(\mathrm{V}_{\text {OUT }}=0.1 \mathrm{rms}\right)$ <br> $1 \%$ Amplitude Error (C $\mathrm{C}_{\text {LOAD }}=1000 \mathrm{pF}$ ) <br> Slew Rate (Vout 20 pk -pk) <br> Setting Time (to $1 \%, \Delta \mathrm{~V}_{\text {OUT }}=20 \mathrm{~V}$ ) |  | $\begin{aligned} & 1 \\ & 50 \\ & 20 \\ & 2 \end{aligned}$ |  |  | $\begin{aligned} & 1 \\ & 50 \\ & 20 \\ & 2 \end{aligned}$ |  | MHz <br> kHz <br> $\mathrm{V} / \mu \mathrm{s}$ <br> $\mu \mathrm{s}$ |
| $\begin{aligned} & \text { NOISE } \\ & \text { Noise Spectral-Density SF }=10 \mathrm{~V} \\ & \text { SF }=3 \mathrm{~V}^{4} \\ & \text { Wideband Noise } \mathrm{f}=10 \mathrm{~Hz} \text { to } 5 \mathrm{MHz} \\ & \mathrm{f}=10 \mathrm{~Hz} \text { to } 10 \mathrm{kHz} \end{aligned}$ |  | $\begin{aligned} & 0.8 \\ & 0.4 \\ & 1.0 \\ & 90 \end{aligned}$ |  |  | $\begin{aligned} & 0.8 \\ & 0.4 \\ & 1.0 \\ & 90 \end{aligned}$ |  | $\begin{aligned} & \mu \mathrm{V} / \sqrt{\mathrm{Hz}} \\ & \mu \mathrm{~V} / \sqrt{\mathrm{Hz}} \\ & \mathrm{mV} / \mathrm{rms} \\ & \mu \mathrm{~V} / \mathrm{rms} \end{aligned}$ |
| OUTPUT <br> Output Voltage Swing <br> Output Impedance ( $\mathrm{f} \leq 1 \mathrm{kHz}$ ) <br> Output Short Circuit Current $\left(\mathrm{R}_{\mathrm{L}}=0, \mathrm{~T}_{\mathrm{A}}=\min \text { to } \max \right)$ <br> Amplifier Open Loop Gain ( $\mathrm{f}=50 \mathrm{~Hz}$ ) | $\pm 11$ | $\begin{aligned} & 0.1 \\ & \\ & 30 \\ & 70 \end{aligned}$ |  | $\pm 11$ | $\begin{aligned} & 0.1 \\ & 30 \\ & 70 \end{aligned}$ |  | $\begin{aligned} & \mathrm{V} \\ & \Omega \\ & \mathrm{~mA} \\ & \mathrm{~dB} \end{aligned}$ |
| INPUT AMPLIFIERS ( $\mathrm{X}, \mathrm{Y}$ and Z ) ${ }^{5}$ <br> Signal Voltage Range (Diff. or CM Operating Diff.) <br> Offset Voltage X, Y <br> Offset Voltage Drift X, Y <br> Offset Voltage Z <br> Offset Voltage Drift Z <br> CMRR <br> Bias Current <br> Offset Current <br> Differential Resistance |  | $\begin{aligned} & \pm 10 \\ & \pm 12 \\ & \pm 5 \\ & 100 \\ & \pm 5 \\ & \\ & 80 \\ & 0.8 \\ & 0.1 \\ & 10 \end{aligned}$ | $\begin{aligned} & \pm 20 \\ & \pm 30 \\ & 500 \\ & 2.0 \end{aligned}$ |  | $\begin{aligned} & \pm 10 \\ & \pm 12 \\ & \pm 2 \\ & 150 \\ & \pm 2 \\ & \\ & 90 \\ & 0.8 \\ & 0.1 \\ & 10 \end{aligned}$ | $\begin{aligned} & \pm 10 \\ & \pm 15 \\ & 300 \\ & 2.0 \end{aligned}$ | v <br> V <br> mV <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ <br> mV <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ <br> dB <br> $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ <br> M $\Omega$ |
| DIVIDER PERFORMANCE $\begin{aligned} & \text { Transfer Function }\left(X_{1}>X_{2}\right) \\ & \text { Total Error } \\ & \qquad \begin{array}{l} (X)=10 \mathrm{~V},-10 \mathrm{~V} \leq \mathrm{Z} \leq+10 \mathrm{~V}) \\ (X=1 \mathrm{~V},-1 \mathrm{~V} \leq \mathrm{Z} \leq+1 \mathrm{~V}) \\ (0.1 V \leq X \leq 10 \mathrm{~V},-10 \mathrm{~V} \leq \\ Z \leq 10 \mathrm{~V}) \\ \hline \end{array} \end{aligned}$ |  | $\begin{array}{r} \left.Z_{2}-Z_{1}\right) \\ X_{1}-X_{2} \\ \pm 0.7 \\ \pm 2.0 \\ \\ \pm 2.5 \end{array}$ |  |  | $\begin{gathered} \left.Z_{2}-Z_{1}\right) \\ \left.\mathbf{X}_{1}-\mathbf{X}_{2}\right) \\ \pm 0.35 \\ \pm 1.0 \\ \pm 1.0 \end{gathered}$ |  | $\begin{aligned} & \% \\ & \% \\ & \% \end{aligned}$ |
| SQUARE PERFORMANCE <br> Transfer Function <br> Total Error ( $-10 \mathrm{~V} \leq \mathrm{X} \leq 10 \mathrm{~V}$ ) | $\begin{gathered} \frac{\left(X_{1}-X_{2}\right)^{2}}{10 \mathrm{~V}}+\mathrm{Z}_{2} \\ \pm 0.6 \end{gathered}$ |  |  | $\begin{gathered} \frac{\left(X_{1}-X_{2}\right)^{2}}{10 V}+Z_{2} \\ \pm 0.3 \end{gathered}$ |  |  | \% |
| SQUARE-ROOTER PERFORMANCE <br> Transfer Function ( $\mathrm{Z}_{1} \leq \mathrm{Z}_{2}$ ) <br> Total Error ${ }^{1}(\mathrm{IV} \leq \mathrm{Z} \leq 10 \mathrm{~V})$ | $\begin{gathered} \sqrt{10 \mathrm{~V}\left(\mathrm{Z}_{2}-\mathrm{Z}_{1}\right)}+\mathrm{X}_{2} \\ \pm 1.0 \end{gathered}$ |  |  | $\begin{gathered} \sqrt{10 V\left(Z_{2}-Z_{1}\right)}+X_{2} \\ \pm 0.5 \end{gathered}$ |  |  | \% |
| POWER SUPPLY SPECIFICATIONS <br> Supply Voltage <br> Rated Performance <br> Operating <br> Supply Current <br> Quiescent | $\pm 15$ |  |  | $\pm 8$ | $\pm 15$ $4$ | $\begin{aligned} & \pm 22 \\ & 6 \end{aligned}$ | V v <br> mA |

## NOTES

${ }^{1}$ Figures given are percent of full scale, $\pm 10 \mathrm{~V}$ (i.e., $0.01 \%=1 \mathrm{mV}$ ).
${ }^{2}$ May be reduced down to 3 V using external resistor between $-\mathrm{V}_{\mathrm{S}}$ and SF .
${ }^{3}$ Irreducible component due to nonlinearity: excludes effect of offsets.
Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All $\min$ and $\max$ specifications are guaranteed, although only those shown in
${ }^{4}$ Using external resistor adjusted to give $\mathbf{S F}=3 \mathrm{~V}$. boldface are tested on all production units.
${ }^{5}$ See functional block diagram for definition of sections.
Specifications subject to change without notice.

## CHIP DIMENSIONS AND BONDING DIAGRAM



THE AD534 IS AVAILABLE IN LASER-TRIMMED CHIP FORM

## Thermal Characteristics.

Thermal Resistance $\theta_{\mathrm{JC}}=25^{\circ} \mathrm{C} / \mathrm{W}$ for $\mathrm{H}-10 \mathrm{~A}$

$$
\begin{aligned}
& \theta_{\mathrm{JA}}=150^{\circ} \mathrm{C} / \mathrm{W} \text { for } \mathrm{H}-10 \mathrm{~A} \\
& \theta_{\mathrm{JC}}=25^{\circ} \mathrm{C} / \mathrm{W} \text { for } \mathrm{D}-14 \text { or } \mathrm{E}-20 \mathrm{~A} \\
& \theta_{\mathrm{JA}}=95^{\circ} \mathrm{C} / \mathrm{W} \text { for } \mathrm{D}-14 \text { or } \mathrm{E}-20 \mathrm{~A}
\end{aligned}
$$

## ABSOLUTE MAXIMUM RATINGS

|  | AD534J, K, L | AD534S, T |
| :--- | :--- | :--- |
| Supply Voltage | $\pm 18 \mathrm{~V}$ | $\pm 22 \mathrm{~V}$ |
| Internal Power Dissipation | 500 mW | $\star$ |
| Output Short-Circuit to Ground | Indefinte | $\star$ |
| Input Voltages, $\mathrm{X}_{1} \mathrm{X}_{2} \mathrm{Y}_{1} \mathrm{Y}_{2} \mathrm{Z}_{1} \mathrm{Z}_{2}$ | $\pm \mathrm{V}_{\mathrm{S}}$ | $\star$ |
| Rated Operating Temperature | 0 to $+70^{\circ} \mathrm{C}$ | $-55^{\circ} \mathrm{C}$ to |
| $\quad$ |  | $+125^{\circ} \mathrm{C}$ |
| $\quad$ Range | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ | $\star$ |
| Storage Temperature Range | $\star$ |  |
| Lead Temperature, 60 s Soldering | $+300^{\circ} \mathrm{C}$ | $\star$ |
| ESD Rating | 1000 V |  |

*Same as AD534J specs.
OPTIONAL TRIMMING CONFIGURATION

ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD534JD | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Side Brazed DIP | D-14 |
| AD534KD | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Side Brazed DIP | D-14 |
| AD534LD | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Side Brazed DIP | D-14 |
| AD534JH | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Header | H-10A |
| AD534KH | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Header | H-10A |
| AD534LH | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Header | H-10A |
| AD534J Chip | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Chip |  |
| AD534K Chip | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Chip |  |
| AD534SD | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Side Brazed DIP | D-14 |
| AD534SD/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Side Brazed DIP | D-14 |
| AD534TD | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Side Brazed DIP | D-14 |
| AD534TD/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Side Brazed DIP | D-14 |
| JM38510/13902BCA | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Side Brazed DIP | D-14 |
| JM38510/13901BCA | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Side Brazed DIP | D-14 |
| AD534SE | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | LCC | E-20A |
| AD534SE/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | LCC | E-20A |
| AD534TE | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | LCC | E-20A |
| AD534TE/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | LCC | E-20A |
| AD534SH | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Header | H-10A |
| AD534SH/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Header | H-10A |
| AD534TH | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Header | H-10A |
| AD534TH/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Header | H-10A |
| JM38510/13902BIA | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Header | H-10A |
| JM38510/13901BIA | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Header | H-10A |
| AD534S Chip | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Chip |  |
| AD534T Chip | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Chip |  |

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## PIN CONFIGURATIONS



LCC (E-20A) Package


## FEATURES

Four-Quadrant Multiplication
Low Cost 8-Pin Package
Complete - No External Components Required
Laser-Trimmed Accuracy and Stability
Total Error Within 2\% of FS
Differential High Impedance $X$ and $Y$ Inputs
High Impedance Unity-Gain Summing Input
Laser-Trimmed 10 V Scaling Reference

## APPLICATIONS

Multiplication, Division, Squaring
Modulation/Demodulation, Phase Detection
Voltage-Controlled Amplifiers/Attenuators/Filters

## PRODUCT DESCRIPTION

The AD633 is a functionally complete, four-quadrant, analog multiplier. It includes high impedance, differential X and Y inputs and a high impedance summing input ( Z ). The low impedance output voltage is a nominal 10 V full scale provided by a buried Zener. The AD633 is the first product to offer these features in modestly priced 8-pin plastic DIP and SOIC packages.
The AD633 is laser calibrated to a guaranteed total accuracy of $2 \%$ of full scale. Nonlinearity for the Y-input is typically less than $0.1 \%$ and noise referred to the output is typically less than $100 \mu \mathrm{~V}$ rms in a 10 Hz to 10 kHz bandwidth. A 1 MHz bandwidth, $20 \mathrm{~V} / \mu \mathrm{s}$ slew rate, and the ability to drive capacitive loads make the AD633 useful in a wide variety of applications where simplicity and cost are key concerns.
The AD633's versatility is not compromised by its simplicity. The Z-input provides access to the output buffer amplifier, enabling the user to sum the outputs of two or more multipliers, increase the multiplier gain, convert the output voltage to a current, and configure a variety of applications.

The AD633 is available in an 8 -pin plastic mini-DIP package $(\mathrm{N})$ and 8 -pin SOIC $(\mathrm{R})$ and is specified to operate over the $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ commercial temperature range.

## CONNECTION DIAGRAMS



8-Pin Plastic SOIC (R) Package


## PRODUCT HIGHLIGHTS

1. The AD633 is a complete four-quadrant multiplier offered in low cost 8 -pin plastic packages. The result is a product that is cost effective and easy to apply.
2. No external components or expensive user calibration are required to apply the AD633.
3. Monolithic construction and laser calibration make the device stable and reliable.
4. High ( $10 \mathrm{M} \Omega$ ) input resistances make signal source loading negligible.
5. Power supply voltages can range from $\pm 8 \mathrm{~V}$ to $\pm 18 \mathrm{~V}$. The internal scaling voltage is generated by a stable Zener diode; multiplier accuracy is essentially supply insensitive.

AD633-SPECIFICATIONS
$\left(T_{A}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{R}_{\mathrm{L}} \geq 2 \mathrm{k} \Omega\right)$


NOTES
Specifications shown in boldface are tested on all production units at electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.
Specifications subject to change without notice.

[^241]ORDERING GUIDE

| Model | Description | Package <br> Option |
| :--- | :--- | :--- |
| AD633JN | 8-Pin Plastic DIP | N-8 |
| AD633JR | 8-Pin Plastic SOIC | R-8 |
| AD633JR-REEL | 8-Pin Plastic SOIC | R-8 |

*For outline information see Package Information section.

FEATURES
High Accuracy
0.1\% Typical Error

High Speed
10 MHz Full-Power Bandwidth
450 V/ $\mu \mathrm{s}$ Slew Rate
200 ns Settling to $\mathbf{0 . 1 \%}$ at Full Power
Low Distortion
-80 dBc from Any Input
Third-Order IMD Typically -75 dBc at $10 \mathbf{~ M H z}$
Low Noise
94 dB SNR, 10 Hz to 20 kHz
70 dB SNR, 10 Hz to 10 MHz
Direct Division Mode
$2 \mathbf{~ M H z ~ B W ~ a t ~ G a i n ~ o f ~} 100$
APPLICATIONS
High Performance Replacement for AD534
Multiply, Divide, Square, Square Root
Modulator, Demodulator
Wideband Gain Control, RMS-DC Conversion
Voltage-Controlled Amplifiers, Oscillators, and Filters
Demodulator with $\mathbf{4 0} \mathbf{~ M H z}$ Input Bandwidth

## PRODUCT DESCRIPTION

The AD734 is an accurate high speed, four-quadrant analog multiplier that is pin-compatible with the industry-standard AD534 and provides the transfer function $W=X Y / U$. The AD734 provides a low-impedance voltage output with a fullpower ( $20 \mathrm{~V} \mathrm{pk}-\mathrm{pk}$ ) bandwidth of 10 MHz . Total static error (scaling, offsets, and nonlinearities combined) is $0.1 \%$ of Full Scale. Distortion is typically less than -80 dBc and guaranteed. The low-capacitance $\mathrm{X}, \mathrm{Y}$ and Z inputs are fully differential. In most applications, no external components are required to define the function.

The internal scaling (denominator) voltage U is 10 V , derived from a buried-Zener voltage reference. A new feature provides the option of substituting an external denominator voltage, allowing the use of the AD734 as a two-quadrant divider with a 1000:1 denominator range and a signal bandwidth that remains 10 MHz to a gain of $20 \mathrm{~dB}, 2 \mathrm{MHz}$ at a gain of 40 dB and 200 kHz at a gain of 60 dB , for a gain-bandwidth product of 200 MHz .
The advanced performance of the AD734 is achieved by a combination of new circuit techniques, the use of a high speed complementary bipolar process and a novel approach to lasertrimming based on ac signals rather than the customary dc methods. The wide bandwidth ( $>40 \mathrm{MHz}$ ) of the AD734's input stages and the 200 MHz gain-bandwidth product of the multiplier core allow the AD734 to be used as a low distortion demodulator with input frequencies as high as 40 MHz as long as the desired output frequency is less than 10 MHz .

The AD734AQ and AD734BQ are specified for the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ and come in a 14 -pin
This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

## CONNECTION DIAGRAM



## FUNCTIONAL BLOCK DIAGRAM


ceramic DIP. The AD734SQ/883B, available processed to MIL-STD-883B for the military range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$, is available in a 14 -pin ceramic DIP.

## PRODUCT HIGHLIGHTS

The AD734 embodies more than two decades of experience in the design and manufacture of analog multipliers, to provide:

1. A new output amplifier design with more than twenty times the slew-rate of the AD534 ( $450 \mathrm{~V} / \mu \mathrm{s}$ versus $20 \mathrm{~V} / \mu \mathrm{s}$ ) for a full power ( $20 \mathrm{~V} \mathrm{pk-pk}$ ) bandwidth of 10 MHz :
2. Very low distortion, even at full power, through the use of circuit and trimming techniques that virtually eliminate all of the spurious nonlinearities found in earlier designs.
3. Direct control of the denominator, resulting in higher multiplier accuracy and a gain-bandwidth product at small denominator values that is typically 200 times greater than that of the AD534 in divider modes.
4. Very clean transient response, achieved through the use of a novel input stage design and wide-band output amplifier, which also ensure that distortion remains low even at high frequencies.
5. Superior noise performance by careful choice of device geometries and operating conditions, which provide a guaranteed 88 dB of dynamic range in a 20 kHz bandwidth.

TRANSFER FUNCTION

$$
W=A_{O}\left\{\frac{\left(X_{1}-X_{2}\right)\left(Y_{1}-Y_{2}\right)}{\left(U_{1}-U_{2}\right)}-\left(Z_{1}-Z_{2}\right)\right\}
$$



## NOTES

${ }^{1}$ Figures given are percent of full scale (e.g., $0.01 \%=1 \mathrm{mV}$ ).
${ }^{2} \mathrm{dBc}$ refers to deciBels relative to the full scale input (carrier) level of 7 V rms.
${ }^{3}$ See Figure 10 for test circuit.
All min and max specifications are guaranteed. Specifications in Boldface are tested on all production units at final electrical test.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 18$ V Internal Power Dissipation ${ }^{2}$
for $T_{\mathrm{J}} \max =175^{\circ} \mathrm{C} . . . . . . . . . . . . . . . . . . . . . .500 \mathrm{~mW}$
X, Y and Z Input Voltages . . . . . . . . . . . . . . . . . VN to VP
Output Short Circuit Duration . . . . . . . . . . . . . . . Indefinite
Storage Temperature Range
Q . . . . . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Operating Temperature Range
AD734A, B (Industrial) . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
AD734S (Military) . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Lead Temperature Range (soldering 60 sec ) . . . . . . . . $+300^{\circ} \mathrm{C}$
Transistor Count 81
ESD Rating . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 500 V

## NOTES

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied.
${ }^{2} 14$-Pin Ceramic DIP: $\theta_{\text {JA }}=110^{\circ} \mathrm{C} / \mathrm{W}$

## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD734AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Plastic DIP | $\mathrm{N}-14$ |
| AD734BN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Plastic DIP | $\mathrm{N}-14$ |
| AD734AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Cerdip | $\mathrm{Q}-14$ |
| AD734BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Cerdip | $\mathrm{Q}-14$ |
| AD734SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Cerdip | $\mathrm{Q}-14$ |
| AD734SQ $/ 883 \mathrm{~B}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Cerdip | $\mathrm{Q}-14$ |
| AD734S Chip | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Chip |  |

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## CHIP DIMENSIONS \& BONDING DIAGRAM

Dimensions shown in inches and (mm).
(Contact factory for latest dimensions.)


## 500MHz Four-Quadrant Multiplier

FEATURES

DC to $>500 \mathrm{MHz}$ Operation Differential $\pm 1 \mathrm{~V}$ Full Scale Inputs Differential $\pm 4 \mathrm{~mA}$ Full Scale Output Current Low Distortion ( $\leq \mathbf{0 . 0 5 \%}$ for $\mathbf{0 d B m}$ Input) Supply Voltages from $\pm \mathbf{4 V}$ to $\pm \mathbf{9 V}$ Low Power ( 280 mW typical at $\mathrm{V}_{\mathrm{s}}= \pm 5 \mathrm{~V}$ )<br>\section*{APPLICATIONS}<br>High Speed Real Time Computation Wideband Modulation and Gain Control Signal Correlation and RF Power Measurement Voltage Controlled Filters and Oscillators Linear Keyers for High Resolution Television Wideband True RMS

## PRODUCT DESCRIPTION

The AD834 is a monolithic laser-trimmed four-quadrant analog multiplier intended for use in high frequency applications, having a transconductance bandwidth $\left(R_{L}=50 \Omega\right)$ in excess of 500 MHz from either of the differential voltage inputs. In multiplier modes, the typical total full scale error is $0.5 \%$, dependent on the application mode and the external circuitry. Performance is relatively insensitive to temperature and supply variations, due to the use of stable biasing based on a bandgap reference generator and other design features.

To preserve the full bandwidth potential of the high speed bipolar process used to fabricate the AD834, the outputs appear as a differential pair of currents at open collectors. To provide a single ended ground referenced voltage output, some form of external current to voltage conversion is needed. This may take the form of a wideband transformer, balun, or active circuitry such as an op amp. In some applications (such as power measurement) the subsequent signal processing may not need to have high bandwidth.
The transfer function is accurately trimmed such that when $\mathrm{X}=\mathrm{Y}= \pm 1 \mathrm{~V}$, the differential output is $\pm 4 \mathrm{~mA}$. This absolute calibration allows the outputs of two or more AD834s to be summed with precisely equal weighting, independent of the accuracy of the load circuit.

The AD834J is specified for use over the commercial temperature range of 0 to $+70^{\circ} \mathrm{C}$ and is available in an 8 -pin plastic DIP package and an 8 -pin plastic SOIC package. AD834A is available in cerdip for operation over the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. The AD834S/883B is specified for operation over the military temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ and is available in the 8 -pin cerdip package. S-Grade chips are also available.

FUNCTIONAL BLOCK DIAGRAM


Two application notes featuring the AD834 (AN-212 and AN-216) can now be obtained by calling 1-800-ANALOG-D. For additional applications circuits, consult the AD811 data sheet.

## PRODUCT HIGHLIGHTS

1. The AD834 combines high static accuracy (low input and output offsets and accurate scale factor) with very high bandwidth. As a four-quadrant multiplier or squarer, the response extends from dc to an upper frequency limited mainly by packaging and external board layout considerations. A large signal bandwidth of over 500 MHz is attainable under optimum conditions.
2. The AD834 can be used in many high speed nonlinear operations, such as square rooting, analog division, vector addition and rms-to-dc conversion. In these modes, the bandwidth is limited by the external active components.
3. Special design techniques result in low distortion levels (better than -60 dB on either input) at high frequencies and low signal feedthrough (typically -65 dB up to 20 MHz ).
4. The AD834 exhibits low differential phase error over the input range-typically $0.08^{\circ}$ at 5 MHz and $0.8^{\circ}$ at 50 MHz . The large signal transient response is free from overshoot, and has an intrinsic rise time of 500 ps , typically settling to within $1 \%$ in under 5 ns .
5. The nonloading, high impedance, differential inputs simplify the application of the AD834.


## NOTES

${ }^{1}$ Error is defined as the maximum deviation from the ideal output, and expressed as a percentage of the full scale output.
${ }^{2}$ Both supplies taken simultaneously; sinusoidal input at $\mathrm{f} \leq 10 \mathrm{kHz}$.
${ }^{3}$ Linearity is defined as residual error after compensating for input offset voltage, output offset current and scaling current errors.
${ }^{4}$ Bandwidth is guaranteed when configured in squarer mode. See Figure 5.
${ }^{5}$ Sine input; relative to full scale output; zero input port nulled; represents feedthrough of the fundamental.
${ }^{6}$ Negative supply current is equal to the sum of positive supply current, the signal currents into each output, W1 and W2, and the input bias currents. Specifications in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. Specifications subject to change without notice.

ABSOLUTE MAXIMUM RATINGS ${ }^{1}$
Supply Voltage ( $+\mathrm{V}_{\mathrm{S}}$ to $-\mathrm{V}_{\mathrm{S}}$ ) . . . . . . . . . . . . . . . . . . . 18V
Internal Power Dissipation . . . . . . . . . . . . . . . . . . . 500mW
Input Voltages (X1, X2, Y1, Y2) . . . . . . . . . . . . . . . . + + V
Operating Temperature Range
AD834J . . . . . . . . . . . . . . . . . . . . . . . . . . . 0 to $+70^{\circ} \mathrm{C}$
AD834A . . . . . . . . . . . . $+80^{\circ} \mathrm{C}$
AD834S/883B . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$

AD834S/883B . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range (Q) . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Storage Temperature Range ( $\mathrm{R}, \mathrm{N}$ ) . . . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Lead Temperature, Soldering 60sec . . . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
ESD Rating . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 500 V

## NOTE

${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## THERMAL CHARACTERISTICS

|  | $\theta_{\mathrm{JC}}$ | $\theta_{\mathrm{JA}}$ |
| :--- | :--- | :--- |
| 8-Pin Cerdip Package (Q) | $30^{\circ} \mathrm{C} / \mathrm{W}$ | $110^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin Plastic SOIC (R) | $45^{\circ} \mathrm{C} / \mathrm{W}$ | $165^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Pin Plastic Mini-DIP (N) | $50^{\circ} \mathrm{C} / \mathrm{W}$ | $99^{\circ} \mathrm{C} / \mathrm{W}$ |

ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Option |
| :--- | :--- | :--- |
| AD834JN | 0 to $+70^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| AD834JR | 0 to $+70^{\circ} \mathrm{C}$ | R-8 |
| AD834JR-REEL | 0 to $+70^{\circ} \mathrm{C}$ | R-8 |
| AD834AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Q-8 |
| AD834SQ/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Q-8 |
| AD834S Chips |  | Chips |

[^243]CONNECTION DIAGRAM


## METALIZATION PHOTOGRAPH

 CHIP DIMENSIONS AND BONDING DIAGRAMDimensions shown in inches and (mm).
Contact factory for latest dimensions.


## FEATURES

Simple: Basic Function is $\mathbf{W}=\mathbf{X Y}+\mathbf{Z}$
Complete: Minimal External Components Required
Very Fast: Settles to $\mathbf{0 . 1 \%}$ of FS in $\mathbf{2 0}$ ns
DC-Coupled Voltage Output Simplifies Use
High Differential Input Impedance X, Y and Z Inputs
Low Multiplier Noise: $\mathbf{5 0} \mathbf{n V} / \sqrt{\mathrm{Hz}}$

## APPLICATIONS

Very Fast Multiplication, Division, Squaring
Wideband Modulation and Demodulation
Phase Detection and Measurement
Sinusoidal Frequency Doubling
Video Gain Control and Keying
Voltage Controlled Amplifiers and Filters

## PRODUCT DESCRIPTION

The AD835 is a complete four-quadrant voltage output analog multiplier fabricated on an advanced dielectrically isolated complementary bipolar process. It generates the linear product of its X and Y voltage inputs, with a -3 dB output bandwidth of 250 MHz (a small signal rise time of 1 ns ). Full-scale ( -1 V to +1 V ) rise/fall times are 2.5 ns (with the standard $\mathrm{R}_{\mathrm{L}}$ of $150 \Omega$ ) and the settling time to $0.1 \%$ under the same conditions is typically 20 ns .
Its differential multiplication inputs ( $\mathrm{X}, \mathrm{Y}$ ) and its summing input ( $Z$ ) are at high impedance. The low impedance output voltage (W) can provide up to $\pm 2.5 \mathrm{~V}$ and drive loads as low as $25 \Omega$. Normal operation is from $\pm 5 \mathrm{~V}$ supplies.
Though providing state-of-the-art speed, the AD835 is simple to use and versatile. For example, as well as permitting the addition of a signal at the output, the Z input provides the means to operate the AD835 with voltage gains up to about $\times 10$. In this capacity, the very low product noise of this multiplier ( $50 \mathrm{nV} \sqrt{\mathrm{Hz}}$ ) makes it much more useful than earlier products.
The AD835 is available in an 8-pin plastic mini-DIP package $(\mathrm{N})$ and an 8 -pin SOIC (R) and is specified to operate over the $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ industrial temperature range.

FUNCTIONAL BLOCK DIAGRAM


## PRODUCT HIGHLIGHTS

1. The AD835 is the first monolithic 250 MHz four quadrant voltage output multiplier.
2. Minimal external components are required to apply the AD835 to a variety of signal processing applications.
3. High input impedances ( $100 \mathrm{k} \Omega \| 2 \mathrm{pF}$ ) make signal source loading negligible.
4. High output current capability allows low impedance loads to be driven.
5. State of the art noise levels achieved through careful device optimization and the use of a special low noise bandgap voltage reference.
6. Designed to be easy to use and cost effective in applications which formerly required the use of hybrid or board level solutions.

| Model |  | AD835AN/AR |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| TRANSFER FUNCTION |  |  | $\frac{X 2)(Y 1}{U}$ | $+Z$ |  |
| Parameter | Conditions | Min | Typ | Max | Unit |
| INPUT CHARACTERISTICS (X, Y) |  |  |  |  |  |
| Differential Voltage Range | $\mathrm{V}_{\mathrm{CM}}=0$ |  | $\pm 1$ |  | V |
| Differential Clipping Level |  | $\pm 1.2$ | $\pm 1.4$ |  | V |
| Low Frequency Nonlinearity | $\mathrm{X}= \pm 1 \mathrm{~V}, \mathrm{Y}=1 \mathrm{~V}$ |  | 0.3 | 0.5 | \% FS |
|  | $\mathrm{Y}= \pm 1 \mathrm{~V}, \mathrm{X}=1 \mathrm{~V}$ |  | 0.1 | 0.3 | \% FS |
| vs. Temperature | $\mathrm{T}_{\text {MIN }} \text { to } \mathrm{T}_{\text {MAX }}{ }^{1}$ |  |  |  |  |
|  | $\mathrm{X}= \pm 1 \mathrm{~V}, \mathrm{Y}=1 \mathrm{~V}$ |  |  | 0.7 | \% FS |
|  | $\mathrm{Y}= \pm 1 \mathrm{~V}, \mathrm{X}=1 \mathrm{~V}$ |  |  | 0.5 | \% FS |
| Common-Mode Voltage Range |  | -2.5 |  | +3 | V |
| Offset Voltage |  |  | $\pm 3$ | $\pm 20$ | mV |
| vs. Temperature | $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}{ }^{1}$ |  |  | $\pm 25$ | mV |
| CMRR | $\mathrm{f} \leq 100 \mathrm{kHz} ; \pm 1 \mathrm{~V}$ p-p | 70 |  |  | dB |
| Bias Current |  |  | 10 | 20 |  |
| vs. Temperature | $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}{ }^{1}$ |  |  | $27$ | $\mu \mathrm{A}$ |
| Offset Bias Current |  |  | 2 |  | $\mu \mathrm{A}$ |
| Differential Resistance |  |  | 100 |  | k $\Omega$ |
| Single-Sided Capacitance |  |  | 2 |  | pF |
| Feedthrough, X | $\mathrm{X}= \pm 1 \mathrm{~V}, \mathrm{Y}=0 \mathrm{~V}$ |  |  | -46 | dB |
| Feedthrough, Y | $\mathrm{Y}= \pm 1 \mathrm{~V}, \mathrm{X}=0 \mathrm{~V}$ |  |  | -60 | dB |
| DYNAMIC CHARACTERISTICS |  |  |  |  |  |
| -3 dB Small-Signal Bandwidth |  | 150 | 250 |  | MHz |
| -0.1 dB Gain Flatness Frequency |  |  | 15 |  | MHz |
| Slew Rate | $\mathrm{W}=-2.5 \mathrm{~V}$ to +2.5 V |  | 1000 |  | V/ $/ \mathrm{s}$ |
| Differential Gain Error, X | $\mathrm{f}=3.58 \mathrm{MHz}$ |  | 0.3 |  |  |
| Differential Phase Error, X | $\mathrm{f}=3.58 \mathrm{MHz}$ |  | 0.2 |  | Degrees |
| Differential Gain Error, Y | $\mathrm{f}=3.58 \mathrm{MHz}$ |  | 0.1 |  | \% |
| Differential Phase Error, Y | $\mathrm{f}=3.58 \mathrm{MHz}$ |  | 0.1 |  | Degrees |
| Harmonic Distortion |  |  |  |  |  |
|  | $\begin{aligned} & \text { Fund }=10 \mathrm{MHz} \\ & \text { Fund }=50 \mathrm{MHz} \end{aligned}$ |  | -70 -40 |  | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \end{aligned}$ |
| Settling Time, X or Y | To $0.1 \%, \mathrm{~W}=2 \mathrm{~V}$ p-p |  | 20 |  |  |
| SUMMING INPUT (Z) |  |  |  |  |  |
| Gain | From Z to W, $\mathrm{f} \leq 10 \mathrm{MHz}$ | 0.990 | 0.995 |  |  |
| -3 dB Small-Signal Bandwidth |  |  | 250 |  | MHz |
| Differential Input Resistance |  |  | 60 |  | $\mathrm{k} \Omega$ |
| Single Sided Capacitance |  |  | 2 |  | pF |
| Maximum Gain | X, Y to W, Z Shorted to W, $\mathrm{f}=1 \mathrm{kHz}$ |  | 50 |  | dB |
| Bias Current |  |  | 50 |  | $\mu \mathrm{A}$ |
| OUTPUT CHARACTERISTICS |  |  |  |  |  |
| Voltage Swing |  | $\pm 2.2$ | $\pm 2.5$ |  | V |
| vs. Temperature | $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}{ }^{1}$ | $\pm 2.0$ |  |  |  |
| Voltage Noise Spectral Density | $\mathrm{X}=\mathrm{Y}=0, \mathrm{f}<10 \mathrm{MHz}$ |  | 50 |  | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| Offset Voltage |  |  | $\pm 25$ | $\pm 75$ | mV |
| vs. Temperature ${ }^{2}$ | $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}{ }^{1}$ |  |  | $\pm 10$ | mV |
| Short Circuit Current |  |  |  |  | mA |
| Scale Factor Error |  |  | $\pm 5$ | $\pm 8$ | \% FS |
| vs. Temperature | $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}{ }^{1}$ |  |  | $\pm 9$ | \% FS |
| Linearity (Relative Error) ${ }^{3}$ |  |  | $\pm 0.5$ | $\pm 1.0$ | \% FS |
| vs. Temperature | $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}{ }^{1}$ |  |  | $\pm 1.25$ | \% FS |
| POWER SUPPLIES |  |  |  |  |  |
| Supply Voltage |  |  |  |  |  |
| For Specified Performance |  | $\pm 4.5$ | $\pm 5$ | $\pm 5.5$ | V |
| Quiescent Supply Current |  |  | 16 | 25 | mA |
| vs. Temperature | $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}{ }^{1}$ |  |  | 26 | mA |
| PSRR at Output vs. Vp | +4.5 V to +5.5 V |  |  | 0.5 | \%/V |
| PSRR at Output vs. Vn | -4.5 V to -5.5 V |  |  | 0.5 | \%/V |

## NOTES

${ }^{1} \mathrm{~T}_{\text {MIN }}=-40^{\circ} \mathrm{C}, \mathrm{T}_{\text {MAX }}=+85^{\circ} \mathrm{C}$.
${ }^{2}$ Normalized to zero at $+25^{\circ} \mathrm{C}$.
${ }^{3}$ Linearity is defined as residual error after compensating for input offset, output voltage offset and scale factor errors.
All min and max specifications are guaranteed. Specifications in boldface are tested on all production units at final electrical test.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 6$ V Internal Power Dissipation ${ }^{2}$. . . . . . . . . . . . . . . . . . . 300 mW
Operating Temperature Range . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to +85 C
Storage Temperature Range . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature, Soldering $60 \mathrm{sec} . . . . . . . . . . . . .+300^{\circ} \mathrm{C}$
ESD Rating . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 1500 V
NOTES
'Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum ratings for extended periods may affect device reliability.
${ }^{2}$ Thermal Characteristics:
8 -Pin Plastic DIP (N): $\theta_{\mathrm{JC}}=35^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JA}}=90^{\circ} \mathrm{C} / \mathrm{W}$
8 -Pin Plastic SOIC (R): $\theta_{\mathrm{JC}}=45^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JA}}=115^{\circ} \mathrm{C} / \mathrm{W}$.

PIN CONNECTIONS
8-Pin Plastic DIP (N)
8-Pin Plastic SOIC (R)


ORDERING GUIDE

| Model | Temperature Range | Package Options ${ }^{\star}$ |
| :--- | :--- | :--- |
| AD835AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{N}-8$ |
| AD835AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-8$ |

* $\mathrm{N}=$ Plastic DIP; R = Small Outline IC Plastic Package (SOIC). For outline information see Package information section


Figure 3. Gain \& Phase vs. Frequency of $X, Y, Z$ Inputs


Figure 4. Gain Flatness to $0.1 d B$

Figure 2. Typical Composite Output Differential Gain \& Phase, NTSC for Y Channel; $f=3.58 \mathrm{MHz}, R_{L}=150 \Omega$


Figure 5. $X$ and $Y$ Feedthrough vs. Frequency


Figure 6. Small Signal Pulse Response at W Output, $R_{L}=$ $150 \Omega, C_{L} \leq 5 \mathrm{pF}, X$ Channel $= \pm 0.2 \mathrm{~V}, Y$ Channel $= \pm 1.0 \mathrm{~V}$


Figure 7. Large Signal Pulse Response at W Output, $R_{L}=$ $150 \Omega, C_{L} \leq 5 \mathrm{pF}, X$ Channel $= \pm 1.0 \mathrm{~V}, Y$ Channel $= \pm 1.0 \mathrm{~V}$


Figure 8. CMRR vs. Frequency for $X$ or $Y$ Channel, $R_{L}=150 \Omega, C_{L} \leq 5 p F$


Figure 9. PSRR vs. Frequency for $V+$ and $V$-Supply


Figure 10. Harmonic Distortion at $10 \mathrm{MHz} ; 10 \mathrm{dBm}$ Input to $X$ or $Y$ Channels, $R_{L}=150 \Omega, C_{L}=\leq 5 p F$


Figure 11. Harmonic Distortion at $50 \mathrm{MHz}, 10 \mathrm{dBm}$ Input to $X$ or $Y$ Channel, $R_{L}=150 \Omega, C_{L} \leq 5 p F$


Figure 12. Harmonic Distortion at $100 \mathrm{MHz}, 10 \mathrm{dBm}$ Input to $X$ or $Y$ Channel, $R_{L}=150 \Omega, C_{L} \leq 5 p F$


Figure 13. Maximum Output Voltage Swing, $R_{L}=50 \Omega$, $C_{L} \leq 5 p F$


Figure 14. Vos Output Drift vs. Temperature


Figure 15. Fixed LO on Y Channel vs. RF Frequency Input to $X$ Channel


Figure 16. Fixed IF vs. LO Frequency on Y Channel

## PRODUCT DESCRIPTION

The AD835 is a four-quadrant, voltage output, analog multiplier fabricated on an advanced, dielectrically isolated, complementary bipolar process. In its basic mode, it provides the linear product of its X and Y voltage inputs. In this mode, the -3 dB output voltage bandwidth is 250 MHz (a small signal rise time of 1 ns ). Full-scale ( -1 V to +1 V ) rise/fall times are 2.5 ns (with the standard $\mathrm{R}_{\mathrm{L}}$ of $150 \Omega$ ) and the settling time to $0.1 \%$ under the same conditions is typically 20 ns .
As in earlier multipliers from Analog Devices, a unique summing feature is provided at the Z -input. As well as providing independent ground references for inputs and output, and enhanced versatility, this feature allows the AD835 to operate with voltage gain. Its X -, Y - and Z -input voltages are all nominally $\pm 1$ V FS, with overrange of at least $20 \%$. The inputs are fully differential and at high impedance ( $100 \mathrm{k} \Omega \| 2 \mathrm{pF}$ ) and provide a 70 dB CMRR ( $\mathrm{f} \leq 1 \mathrm{MHz}$ ).
The low impedance output is capable of driving loads as small as $25 \Omega$. The peak output can be as large as $\pm 2.2 \mathrm{~V}$ minimum for $R_{L}=150 \Omega$, or $\pm 2.0 \mathrm{~V}$ minimum into $R_{L}=50 \Omega$. The
AD835 has much lower noise than the AD534 or AD734, making it attractive in low level signal-processing applications, for example, as a wideband gain-control element or modulator.

## Basic Theory

The multiplier is based on a classic form, having a translinear core, supported by three ( $\mathrm{X}, \mathrm{Y}, \mathrm{Z}$ ) linearized voltage-to-current converters, and the load driving output amplifier. The scaling voltage (the denominator $U$, in the equations below) is provided by a bandgap reference of novel design, optimized for ultralow noise. Figure 17 shows the functional block diagram.
In general terms, the AD835 provides the function

$$
\begin{equation*}
W=\frac{(X 1-X 2)(Y 1-Y 2)}{U}+Z \tag{1}
\end{equation*}
$$

where the variables $\mathrm{W}, \mathrm{U}, \mathrm{X}, \mathrm{Y}$ and Z are all voltages. Connected as a simple multiplier, with $\mathrm{X}=\mathrm{X} 1-\mathrm{X} 2, \mathrm{Y}=\mathrm{Y} 1-\mathrm{Y} 2$ and $Z=0$, and with a scale factor adjustment (see below) which sets $U=1 \mathrm{~V}$, the output can be expressed as

$$
\begin{equation*}
W=X Y \tag{2}
\end{equation*}
$$



Figure 17. Functional Block Diagram

Simplified representations of this sort, where all signals are presumed to be expressed in volts, are used throughout this data sheet, to avoid the needless use of less-intuitive subscripted variables (such as $\mathrm{V}_{\mathrm{x} 1}$ ). We can view all variables as being normalized to 1 V . For example, the input X can either be stated as being in the range -1 V to +1 V , or simply -1 to +1 . The latter representation will be found to facilitate the development of new functions using the AD835. The explicit inclusion of the denominator, U , is also less helpful, as in the case of the AD835, if it is not an electrical input variable.

## Scaling Adjustment

The basic value of U in Equation 1 is nominally 1.05 V . Figure 18, which shows the basic multiplier connections, also shows how the effective value of U can be adjusted to have any lower voltage (usually 1 V ) through the use of a resistive-divider between W (Pin 5) and Z (Pin 4). Using the general resistor values shown, we can rewrite Equation 1 as

$$
\begin{equation*}
W=\frac{X Y}{U}+k W+(1-k) Z^{\prime} \tag{3}
\end{equation*}
$$

(where $Z^{\prime}$ is distinguished from the signal $Z$ at $\operatorname{Pin} 4$ ). It follows that

$$
\begin{equation*}
W=\frac{X Y}{(1-k) U}+Z^{\prime} \tag{4}
\end{equation*}
$$

In this way, we can modify the effective value of $U$ to

$$
\begin{equation*}
U^{\prime}=(1-k) U \tag{5}
\end{equation*}
$$

without altering the scaling of the $Z^{\prime}$ input. (This is to be expected, since the only "ground reference" for the output is through the $\mathrm{Z}^{\prime}$ input.)
Thus, to set $U^{\prime}$ to 1 V , remembering that the basic value of U is 1.05 V , we need to choose R1 to have a nominal value of 20 times R2. The values shown here allow U to be adjusted through the nominal range 0.95 V to 1.05 V , that is, R2 provides a 5\% gain adjustment.


Figure 18. Multiplier Connections
Note that in many applications, the exact gain of the multiplier may not be very important; in which case, this network may be omitted entirely, or R2 fixed at $100 \Omega$.

ANALOG DEVICES

# Four-Channel, Four-Quadrant Analog Multiplier 

## FEATURES

## Four Independent Channels

Voltage IN, Voltage OUT
No External Parts Required

## 8 MHz Bandwidth

## Four-Quadrant Multiplication

Voltage Output; $\mathbf{W}=(\mathrm{X} \times \mathrm{Y}) / 2.5 \mathrm{~V}$
$0.2 \%$ Typical Linearity Error on $X$ or $Y$ Inputs
Excellent Temperature Stability: 0.005\%
$\pm 2.5$ V Analog Input Range
Operates from $\pm 5$ V Supplies
Low Power Dissipation: 150 mW typ
Spice Model Available

## APPLICATIONS

## Geometry Correction in High-Resolution CRT Displays <br> Waveform Modulation \& Generation <br> Voltage Controlled Amplifiers <br> Automatic Gain Control <br> Modulation and Demodulation

## GENERAL DESCRIPTION

The MLT04 is a complete, four-channel, voltage output analog multiplier packaged in an 18-pin DIP or SOIC-18. These complete multipliers are ideal for general purpose applications such as voltage controlled amplifiers, variable active filters, "zipper" noise free audio level adjustment, and automatic gain control. Other applications include cost-effective multiple-channel power calculations $(\mathrm{I} \times \mathrm{V}$ ), polynomial correction generation, and low frequency modulation. The MLT04 multiplier is ideally suited for generating complex, high-order waveforms especially suitable for geometry correction in high-resolution CRT display systems.

FUNCTIONAL BLOCK DIAGRAM
18-Lead Epoxy DIP (P Suffix)
18-Lead Wide Body SOIC (S Suffix)

$\mathrm{W}=(\mathrm{X} \cdot \mathrm{Y}) / 2.5 \mathrm{~V}$

Fabricated in a complementary bipolar process, the MLT04 includes four 4-quadrant multiplying cells which have been lasertrimmed for accuracy. A precision internal bandgap reference normalizes signal computation to a 0.4 scale factor. Drift over temperature is under $0.005 \% /{ }^{\circ} \mathrm{C}$. Spot noise voltage of $0.3 \mu \mathrm{~V} / \mathrm{VHz}$ results in a THD + Noise performance of $0.02 \%$ (LPF $=22 \mathrm{kHz}$ ) for the lower distortion Y channel. The four 8 MHz channels consume a total of 150 mW of quiescent power.

The MLT04 is available in 18 -pin plastic DIP, and SOIC-18 surface mount packages. All parts are offered in the extended industrial temperature range $\left(-40^{\circ} \mathrm{C}\right.$ to $\left.+85^{\circ} \mathrm{C}\right)$.


Figure 1. Gain \& Phase vs. Frequency Response


Figure 2. THD + Noise vs. Frequency

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| MULTIPLIER PERFORMANCE ${ }^{1}$ |  |  |  |  |  |  |
| Total Error ${ }^{2} \mathrm{X}$ | $\mathrm{E}_{\mathrm{x}}$ | $-2.5 \mathrm{~V}<\mathrm{X}<+2.5 \mathrm{~V}, \mathrm{Y}=+2.5 \mathrm{~V}$ | -5 | $\pm 2$ | 5 | \% FS |
| Total Error ${ }^{2} \mathrm{Y}$ | $\mathrm{E}_{\mathrm{Y}}$ | $-2.5 \mathrm{~V}<\mathrm{Y}<+2.5 \mathrm{~V}, \mathrm{X}=+2.5 \mathrm{~V}$ | -5 | $\pm 2$ | 5 | \% FS |
| Linearity Error ${ }^{2} \mathbf{X}$ | $\mathrm{LE}_{\mathrm{x}}$ | $-2.5 \mathrm{~V}<\mathrm{X}<+2.5 \mathrm{~V}, \mathrm{Y}=+2.5 \mathrm{~V}$ | -1 | $\pm 0.2$ | +1 | \% FS |
| Linearity Error ${ }^{2} \mathrm{Y}$ | $\mathrm{LE}_{\mathrm{Y}}$ | $-2.5 \mathrm{~V}<\mathrm{Y}<+2.5 \mathrm{~V}, \mathrm{X}=+2.5 \mathrm{~V}$ | -1 | $\pm 0.2$ | +1 | \% FS |
| Total Error Drift | $\mathrm{TCE}_{\mathrm{X}}$ | $\mathrm{X}=-2.5 \mathrm{~V}, \mathrm{Y}=2.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  | 0.005 |  | \%/ ${ }^{\circ} \mathrm{C}$ |
| Total Error Drift | $\mathrm{TCE}_{\mathrm{Y}}$ | $\mathrm{Y}=-2.5 \mathrm{~V}, \mathrm{X}=2.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  | 0.005 |  | \%/ ${ }^{\circ} \mathrm{C}$ |
| Scale Factor ${ }^{3}$ | K | $\mathrm{X}= \pm 2.5 \mathrm{~V}, \mathrm{Y}= \pm 2.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 0.38 | 0.40 | 0.42 | 1/V |
| Output Offset Voltage | $\mathrm{Z}_{\text {os }}$ | $\mathrm{X}=0 \mathrm{~V}, \mathrm{Y}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | -50 | $\pm 10$ | 50 | mV |
| Output Offset Drift | $\mathrm{TCZ}_{\text {os }}$ | $\mathrm{X}=0 \mathrm{~V}, \mathrm{Y}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  | 50 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Offset Voltage, X | $\mathrm{X}_{\text {os }}$ | $\mathrm{X}=0 \mathrm{~V}, \mathrm{Y}= \pm 2.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | -50 | $\pm 10.5$ | 50 | mV |
| Offset Voltage, Y | $\mathrm{Y}_{\text {os }}$ | $\mathrm{Y}=0 \mathrm{~V}, \mathrm{X}= \pm 2.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | -50 | $\pm 10.5$ | 50 | mV |
| DYNAMIC PERFORMANCE <br> Small Signal Bandwidth |  | $\mathrm{V}_{\text {Out }}=0.1 \mathrm{~V}$ rms |  |  |  |  |
| Small Rate | $\stackrel{\text { BR }}{ }$ | $\mathrm{V}_{\text {out }}=0.1 \mathrm{~V}^{\text {orms }}$ | 30 | 8 5 |  | $\begin{aligned} & \mathrm{MHz} \\ & \mathrm{~V} / \mu \mathrm{s} \end{aligned}$ |
| Settling Time | $\mathrm{t}_{\text {s }}$ | $\mathrm{V}_{\text {Out }}=\Delta 2.5 \mathrm{~V}$ to 1\% Error Band |  | 1 |  |  |
| AC Feedthrough | $\mathrm{FT}_{\mathrm{AC}}$ | $\mathrm{X}=0 \mathrm{~V}, \mathrm{Y}=1 \mathrm{Vrms}$ @ $\mathrm{f}=100 \mathrm{kHz}$ |  | -65 |  | dB |
| Crosstalk @ 100 kHz | $\mathrm{CT}_{\mathrm{AC}}$ | $\mathrm{X}=\mathrm{Y}=1 \mathrm{~V}$ rms Applied to Adjacent Channel |  | -90 |  | dB |
| OUTPUTS |  |  |  |  |  |  |
| Audio Band Noise | $\mathrm{E}_{\mathrm{N}}$ | $\mathrm{f}=10 \mathrm{~Hz}$ to 50 kHz |  | 76 |  | $\mu \mathrm{V}$ rms |
| Wide Band Noise | $\mathrm{E}_{\mathrm{N}}$ | Noise BW $=1.9 \mathrm{MHz}$ |  | 380 |  | $\mu \mathrm{V}$ rms |
| Spot Noise Voltage | $\mathrm{e}_{\mathrm{N}}$ | $\mathrm{f}=1 \mathrm{kHz}$ |  | 0.3 | ) | $\mu \mathrm{V} / \sqrt{ } \mathrm{Hz}$ |
| Total Harmonic Distortion | $\mathrm{THD}_{\mathrm{x}}$ | $\mathrm{f}=1 \mathrm{kHz}, \mathrm{LPF}=22 \mathrm{kHz}, \mathrm{Y}=2.5 \mathrm{~V}$ |  | 0.1 |  |  |
|  | $\mathrm{THD}_{\mathrm{Y}}$ | $\mathrm{f}=1 \mathrm{kHz}, \mathrm{LPF}=22 \mathrm{kHz}, \mathrm{X}=2.5 \mathrm{~V}$ |  | 0.02 |  |  |
| Open Loop Output Resistance | $\mathrm{R}_{\text {OUT }}$ |  |  | 40 |  |  |
| Voltage Swing | $\mathrm{V}_{\mathrm{PK}}$ | $\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-5 \mathrm{~V}$ | $\pm 3.0$ | $\pm 3.3$ |  | $\mathrm{V}_{\mathrm{P}}$ |
| Short Circuit Current | $\mathrm{I}_{\text {Sc }}$ |  |  | 30 |  | mA |
| INPUTS |  |  |  |  |  |  |
| Analog Input Range | IVR | $\mathrm{GND}=0 \mathrm{~V}$ | -2.5 |  | +2.5 | V |
| Bias Current | $\mathrm{I}_{\mathrm{B}}$ | $\mathrm{X}=\mathrm{Y}=0 \mathrm{~V}$ |  | 2.3 | 10 | $\mu \mathrm{A}$ |
| Resistance | $\mathrm{R}_{\mathrm{IN}}$ |  |  | 1 |  | $\mathrm{M} \Omega$ |
| Capacitance | $\mathrm{C}_{\text {IN }}$ |  |  | 3 |  | pF |
| SQUARE PERFORMANCE <br> Total Square Error | $\mathrm{E}_{\text {SQ }}$ | $\mathrm{X}=\mathrm{Y}=1$ |  | 5 |  | \% FS |
| POWER SUPPLIES |  |  |  |  |  |  |
| Positive Current | $\mathrm{I}_{\mathrm{Cc}}$ | $\mathrm{V}_{\mathrm{CC}}=5.25 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-5.25 \mathrm{~V}$ |  | 15 | 20 | mA |
| Negative Current | $\mathrm{I}_{\mathrm{EE}}$ | $\mathrm{V}_{\mathrm{CC}}=5.25 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-5.25 \mathrm{~V}$ |  | 15 | 20 | mA |
| Power Dissipation | $\mathrm{P}_{\text {DISS }}$ | Calculated $=5 \mathrm{~V} \times \mathrm{I}_{\mathrm{CC}}+5 \mathrm{~V} \times \mathrm{I}_{\mathrm{EE}}$ |  | 150 | 200 | mW |
| Supply Sensitivity | PSSR | $\mathrm{X}=\mathrm{Y}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}=\Delta 5 \%$ or $\mathrm{V}_{\mathrm{EE}}=\Delta 5 \%$ |  |  | 10 | $\mathrm{mV} / \mathrm{V}$ |
| Supply Voltage Range | $\mathrm{V}_{\text {RANGE }}$ | For $\mathrm{V}_{\mathrm{CC}}$ \& $\mathrm{V}_{\mathrm{EE}}$ | $\pm 4.75$ |  | $\pm 5.25$ | V |

## NOTES

${ }^{1}$ Specifications apply to all four multipliers.
${ }^{2}{ }^{2}$ Error is measured as a percent of the $\pm 2.5 \mathrm{~V}$ full scale, i.e., $1 \% \mathrm{FS}=25 \mathrm{mV}$.
${ }^{3}$ Scale Factor K is an internally set constant in the multiplier transfer equation $\mathrm{W}=\mathrm{K} \times \mathrm{X} \times \mathrm{Y}$.
Specifications subject to change without notice.

## ORDERING INFORMATION ${ }^{1}$



## ABSOLUTE MAXIMUM RATINGS ${ }^{\star}$

upply Voltages $\mathrm{V}_{\mathrm{CC}}, \mathrm{V}_{\mathrm{EE}}$ to GND

Operating Temperature Range . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Maximum Junction Temperature ( $\mathrm{T}_{\mathrm{J}} \max$ ) . ............. $+150^{\circ} \mathrm{C}$
Storage Temperature ............................................ $+300^{\circ} \mathrm{C}$
Package Power Dissipation . . . . . . . . . . . . . . . . . . . . $\left(\mathrm{T}_{\mathrm{J}} \max -\mathrm{T}_{\mathrm{A}}\right) / \theta_{\mathrm{JA}}$
Thermal Resistance $\theta_{\mathrm{JA}}$
SOIC-18 (SOL-18)
(
*Stresses above those listed under "Absolute Maximum Ratings" may cause permathe device at these or any other conditions above those indicated in the operational section of this specification are not implied.

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| MLT04GP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 18-Pin P-DIP | N-18 |
| MLT04GS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 18-Lead SOIC | SOL-18 |
| MLT04GBC | $+25^{\circ} \mathrm{C}$ | Die |  |

## NOTES

${ }^{1}$ For die specifications contact your local Analog sales office. The MLT04 contains 211 transistors.
${ }^{2}$ For outline information see Package Information section.

## FUNCTIONAL DESCRIPTION

The MLT04 is a low cost quad, 4-quadrant analog multiplier with single-ended voltage inputs and voltage outputs. The functional block diagram for each of the multipliers is illustrated in Figure 3. Due to packaging constraints, access to internal nodes for externally adjusting scale factor, output offset voltage, or additional summing signals is not provided.


Figure 3. Functional Block Diagram of Each MLT04 Multiplier

Each of the MLT04's analog multipliers is based on a Gilbert cell multiplier configuration, a 1.23 V bandgap reference, and a unityconnected output amplifier. Multiplier scale factor is determined through a differential pair/trimmable resistor network external to the core. An equivalent circuit for each of the multipliers is shown in Figure 4.


Figure 4. Equivalent Circuit for the MLT04

Details of each multiplier's output-stage amplifier are shown in Figure 5. The output stages idles at $200 \mu \mathrm{~A}$, and the resistors in series with the emitters of the output stage are $25 \Omega$. The output stage can drive load capacitances up to 500 pF without oscillation. For loads greater than 500 pF , the outputs of the MLT04 should be isolated from the load capacitance with a $100 \Omega$ resistor.


Figure 5. Equivalent Circuit for MLT04 Output Stages

## ANALOG MULTIPLIER ERROR SOURCES

Multiplier errors consist primarily of input and output offsets, scale factor errors, and nonlinearity in the multiplying core. An expression for the output of a real analog multiplier is given by:
$V_{o}=(K+\Delta K)\left\{\left(V_{X}+X_{o s}\right)\left(V_{Y}+Y_{o s}\right)+Z_{o s}+f(X, Y)\right\}$
where: $K=$ Multiplier Scale Factor
$\Delta K=$ Scale Factor Error
$V_{X} \quad=$ X-Input Signal
$X_{o s}=$ X-Input Offset Voltage
$V_{Y} \quad=\quad$ Y-Input Signal
$Y_{o s} \quad=\quad$ Y-Input Offset Voltage
$Z_{o s} \quad=$ Multiplier Output Offset Voltage
$f(X, Y)=$ Nonlinearity
Executing the algebra to simplify the above expression yields expressions for all the errors in an analog multiplier:

| Term | Description | Dependence on Input |
| :---: | :---: | :---: |
| $\mathrm{KV}_{\mathrm{x}} \mathrm{V}_{\mathrm{Y}}$ | True Product | Goes to Zero As Either or Both Inputs Go to Zero |
| $\Delta \mathrm{KV}_{\mathrm{Y}} \mathrm{V}_{\mathrm{Y}}$ | Scale-Factor Error | Goes to Zero at $\mathrm{V}_{\mathrm{X}}, \mathrm{V}_{\mathrm{Y}}=0$ |
| $\mathrm{V}_{\mathrm{X}} \mathrm{Y}_{\mathrm{os}}$ | Linear "X" Feedthrough Due to Y-Input Offset | Proportional to $\mathrm{V}_{\mathrm{x}}$ |
| $\mathrm{V}_{\mathrm{Y}} \mathrm{X}_{\mathrm{os}}$ | Linear "Y" Feedthrough Due to X-Input Offset | Proportional to $\mathrm{V}_{\mathrm{Y}}$ |
| $\mathrm{X}_{\text {os }} \mathrm{Y}_{\text {os }}$ | Output Offset Due to X-, Y-Input Offsets | Independent of $\mathrm{V}_{\mathrm{X}}, \mathrm{V}_{\mathrm{Y}}$ |
| $\mathrm{Z}_{\text {os }}$ | Output Offset | Independent of $\mathrm{V}_{\mathrm{X}}, \mathrm{V}_{\mathrm{Y}}$ |
| $f(\mathrm{X}, \mathrm{Y})$ | Nonlinearity | Depends on Both $\mathrm{V}_{\mathrm{X}}, \mathrm{V}_{\mathrm{Y}}$. Contains Terms Dependent on $\mathrm{V}_{\mathrm{X}}^{\prime}, \mathrm{V}_{\mathrm{Y}}$, Their Powers and Cross Products |

As shown in the table, the primary static errors in an analog multiplier are input offset voltages, output offset voltage, scale factor, and nonlinearity. Of the four sources of error, only two are externally trimmable in the MLT04: the X- and Y-input offset voltages. Output offset voltage in the MLT04 is factory-trimmed to $\pm 50 \mathrm{mV}$, and the scale factor is internally adjusted to $\pm 2.5 \%$ of full scale. Input offset voltage errors can be eliminated by using the optional trim circuit of Figure 6. This scheme then reduces the net error to output offset, scale-factor (gain) error, and an irreducible nonlinearity component in the multiplying core.


Figure 6. Optional Offset Voltage Trim Configuration

## MLT04

## Feedthrough

In the ideal case, the output of the multiplier should be zero if either input is zero. In reality, some portion of the nonzero input will "feedthrough" the multiplier and appear at the output. This is caused by the product of the nonzero input and the offset voltage of the "zero" input. Introducing an offset equal to and opposite of the "zero" input offset voltage will null the linear component of the feedthrough. Residual feedthrough at the output of the multiplier is then irreducible core nonlinearity.
Typical X- and Y-input feedthrough curves for the MLT04 are shown in Figures 7 and 8, respectively. These curves illustrate MLT04 feedthrough after "zero" input offset voltage trim. Residual X-input feedthrough measures $0.08 \%$ of full scale, whereas residual Y-input feedthrough is almost immeasurable.


HORIZONTAL - 0.5V/DIV

Figure 7. $X$-Input Feedthrough with $Y_{o s}$ Nulled


HORIZONTAL - 0.5V/DIV
Figure 8. $Y$-Input Feedthrough with $X_{o s}$ Nulled

## Nonlinearity

Multiplier core nonlinearity is the irreducible component of error. It is the difference between actual performance and "best-straightline" theoretical output, for all pairs of input values. It is expressed as a percentage of full scale with all other dc errors nulled. Typical X - and Y-input nonlinearities for the MLT04 are shown in Figures 9 through 12. Worst-case X-input nonlinearity measured less than $0.2 \%$, and Y-input nonlinearity measured better than $0.06 \%$. For modulator/demodulator or mixer applications it is, therefore, recommended that the carrier be connected to the X -input while the signal is applied to the Y-input.


HORIZONTAL - 0.5V/DIV

Figure 9. $X$-Input Nonlinearity @ $Y=+2.5 V$


HORIZONTAL - 0.5V/DIV

Figure 10. $X$-Input Nonlinearity @ $Y=-2.5$ V


HORIZONTAL - 0.5V/DIV
Figure 11. Y-Input Nonlinearity @ $X=+2.5 \mathrm{~V}$


HORIZONTAL - 0.5V/DIV
Figure 12. $Y$-Input Nonlinearity @ $X=-2.5$ V


Figure 13. Broadband Noise


Figure 14. Broadband Noise


Figure 16. $X$-Input Gain and Phase vs. Frequency


Figure 17. Y-Input Gain and Phase vs. Frequency


Figure 18. Amplitude Response vs. Capacitive Load

## MLTO4 - Typical Performance Characteristics



Figure 19. Feedthrough vs. Frequency


Figure 20. Crosstalk vs. Frequency


Figure 21. Gain Flatness vs. Frequency


Figure 22. Y-Input Small-Signal Transient Response, $C_{L}=30 \mathrm{pF}$


Figure 23. Y-Input Small-Signal Transient Response, $C_{L}=100 \mathrm{pF}$


Figure 24. Y-Input Large-Signal Transient Response, $C_{L}=30 \mathrm{pF}$


Figure 25. Y-Input Large-Signal Transient Response, $C_{L}=100 \mathrm{pF}$


Figure 26. THD + Noise vs. Input Signal Level


Figure 27. Linearity Error vs. Temperature


Figure 28. X-Input Gain Bandwidth vs. Temperature


Figure 29. Y-Input Gain Bandwidth vs. Temperature


Figure 30. Maximum Output Swing vs. Frequency

Figure 31. Maximum Output Swing vs. Resistive Load


Figure 32. Offset Voltage Distribution


Figure 33. Offset Voltage vs. Temperature


Figure 34. Scale Factor Distribution


Figure 35. Scale Factor vs. Temperature


Figure 36. Output Offset Voltage $\left(Z_{o s}\right)$ Distribution


Figure 37. Output Offset Voltage $\left(Z_{o s}\right)$ vs. Temperature


Figure 38. Supply Current vs. Temperature


Figure 39. Power Supply Rejection vs. Frequency


Figure 40. Linearity Error (LE) Distribution Accelerated by Burn-in


Figure 41. Output Voltage Offset $\left(Z_{o s}\right)$ Distribution Accelerated by Burn-in


Figure 42. Scale Factor (K) Distribution Accelerated by Burn-in

## APPLICATIONS

The MLT04 is well suited for such applications as modulation/ demodulation, automatic gain control, power measurement, analog computation, voltage-controlled amplifiers, frequency doublers, and geometry correction in CRT displays.

## Multiplier Connections

Figure 43 llustrates the basic connections for multiplication. Each of the four independent multipliers has single-ended voltage inputs (X, Y) and a low impedance voltage output (W). Also, each multiplier has its own dedicated ground connection (GND) which is connected to the circuit's analog common. For best performance, circuit layout should be compact with short component leads and well-bypassed supply voltage feeds. In applications where fewer than four multipliers are used, all unused analog inputs must be returned to the analog common.


Figure 43. Basic Multiplier Connections

## Squaring and Frequency Doubling

As shown in Figure 44, squaring of an input signal, $\mathrm{V}_{\mathbb{N}}$, is achieved by connecting the X -and Y-inputs in parallel to produce an output of $\mathrm{V}_{\text {IN }}{ }^{2} / 2.5 \mathrm{~V}$. The input may have either polarity, but the output will be positive.


Figure 44. Connections for Squaring
When the input is a sine wave given by $\mathrm{V}_{\mathrm{IN}} \sin \omega \mathrm{t}$, the squaring circuit behaves as a frequency doubler because of the trigonometric identity:

$$
\frac{\left(V_{I N} \sin \omega t\right)^{2}}{2.5 V}=\frac{V_{I N}{ }^{2}}{2.5 V}\left(\frac{1}{2}\right)(1-\cos 2 \omega t)
$$

The equation shows a dc term at the output which will vary strongly with the amplitude of the input, $\mathrm{V}_{\mathrm{N}}$. The output dc offset can be eliminated by capacitively coupling the MLT04's output with a high-pass filter. For optimal spectral performance, the filter's cutoff frequency should be chosen to eliminate the input fundamental frequency.
A source of error in this configuration is the offset voltages of the X and $Y$ inputs. The input offset voltages produce cross products with the input signal to distort the output waveform. To circumvent this problem, Figure 45 illustrates the use of inverting amplifiers configured with an OP285 to provide a means by which the X - and Y -input offsets can be trimmed.


Figure 45. Frequency Doubler with Input Offset Voltage Trims

## Feedback Divider Connections

The most commonly used analog divider circuit is the "inverted multiplier" configuration. As illustrated in Figure 46, an "inverted multiplier" analog divider can be configured with a multiplier operating in the feedback loop of an operational amplifier. The general form of the transfer function for this circuit configuration is given by:

$$
V_{O}=-2.5 V \times\left(\frac{R 2}{R 1}\right) \times \frac{V_{I N}}{V_{X}}
$$

Here, the multiplier operates as a voltage-controlled potentiometer that adjusts the loop gain of the op amp relative to a control signal, $\mathrm{V}_{\mathrm{x}}$. As the control signal to the multiplier decreases, the output of the multiplier decreases as well. This has the effect of reducing negative feedback which, in turn, decreases the amplifier's loop gain. The result is higher closed-loop gain and reduced circuit bandwidth. As $\mathrm{V}_{\mathrm{x}}$ is increased, the output of the multiplier increases which generates more negative feedback - closed-loop gain drops and circuit bandwidth increases. An example of an "inverted multiplier" analog divider frequency response is shown in Figure 47.


Figure 46. "Inverted-Multiplier" Configuration for Analog Division


Figure 47. Signal-Dependent Feedback Makes Variables Out of Amplifier Bandwidth and Stability

Although this technique works well with almost any operational amplifier, there is one caveat: for best circuit stability, the unitygain crossover frequency of the operational amplifier should be equal to or less than the MLT04's 8 MHz bandwidth.

## Connection for Square Rooting

Another application of the "inverted multiplier" configuration is the square-root function. As shown in Figure 48, both inputs of the MLT04 are wired together and are used as the output of the circuit. Because the circuit configuration exhibits the following generalized transfer function:

$$
V_{o}=\sqrt{-2.5 \times\left(\frac{R 2}{R 1}\right) \times V_{I N}}
$$

the input signal voltage is limited to the range $-2.5 \mathrm{~V} \leq \mathrm{V}_{\mathrm{IN}}<0$. To prevent circuit latchup due to positive feedback or input signal polarity reversal, a 1 N 4148 -type junction diode is used in series with the output of the multiplier.


Figure 48. Connections for Square Rooting

## Voltage-Controlled Low-Pass Filter

The circuit in Figure 49 illustrates how to construct a voltagecontrolled low-pass filter with an analog multiplier. The advantage with this approach over conventional active-filter configurations is that the overall characteristic cut-off frequency, $\omega_{0}$, will be directly proportional to a multiplying input voltage. This permits the construction of filters in which the capacitors are adjustable (directly or inversely) by a control voltage. Hence, the frequency scale of a filter can be manipulated by means of a single voltage without affecting any other parameters. The general form of the circuit's transfer function is given by:

$$
\frac{V_{O}}{V_{I N}}=-\left(\frac{R 2}{R 1}\right)\left\{\frac{1}{s\left(\frac{R 2+R 1}{R 1}\right)\left(\frac{2.5 R C}{V_{X}}\right)+1}\right\}
$$

In this circuit, the ratio of R2 to R1 sets the passband gain, and the break frequency of the filter, $\omega_{L P}$, is given by:

$$
\omega_{L P}=\left(\frac{R 1}{R 1+R 2}\right)\left(\frac{V_{X}}{2.5 R C}\right)
$$



Figure 49. A Voltage-Controlled Low-Pass Filter

# RMS-to-DC Converters Contents 


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## Selection Tree - RMS-to-DC Converters



## Selection Guide－RMS－to－DC Converters





 temperature designator will be followed by：／to indicate $883 \mathrm{~B},{ }_{\mathrm{J}}$ for JAN，${ }_{\mathrm{D}}$ for SMD，and ${ }_{\mathrm{s}}$ for space level．
Boldface Type：Data sheet information in this volume．

# Integrated Circuit, True RMS-to-DC Converter 

FEATURES<br>True RMS-to-DC Conversion<br>Laser-Trimmed to High Accuracy<br>0.2\% max Error (AD536AK)<br>0.5\% max Error (AD536AJ)<br>Wide Response Capability: Computes RMS of AC and DC Signals 450kHz Bandwidth: $V_{\text {rms }}>100 \mathrm{mV}$ $\mathbf{2 M H z}$ Bandwidth: $\mathrm{V}_{\text {rms }}>1 \mathrm{~V}$ Signal Crest Factor of 7 for 1\% Error dB Output with 60dB Range<br>Low Power: 1.2mA Quiescent Current<br>Single or Dual Supply Operation<br>Monolithic Integrated Circuit<br>$-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ Operation (AD536AS)

## PRODUCT DESCRIPTION

The AD536A is a complete monolithic integrated circuit which performs true rms-to-dc conversion. It offers performance which is comparable or superior to that of hybrid or modular units costing much more. The AD536A directly computes the true rms value of any complex input waveform containing ac and dc components. It has a crest factor compensation scheme which allows measurements with $1 \%$ error at crest factors up to 7 . The wide bandwidth of the device extends the measurement capability to 300 kHz with 3 dB error for signal levels above 100 mV .
An important feature of the AD536A not previously available in rms converters is an auxiliary dB output. The logarithm of the rms output signal is brought out to a separate pin to allow the dB conversion, with a useful dynamic range of 60 dB . Using an externally supplied reference current, the 0 dB level can be conveniently set by the user to correspond to any input level from 0.1 to 2 volts rms.

The AD536A is laser trimmed at the wafer level for input and output offset, positive and negative waveform symmetry (dc reversal error), and full-scale accuracy at 7 V rms. As a result, no external trims are required to achieve the rated accuracy of the unit.
There is full protection for both inputs and outputs. The input circuitry can take overload voltages well beyond the supply levels. Loss of supply voltage with inputs connected will not cause unit failure. The output is short-circuit protected.
The AD536A is available in two accuracy grades ( $\mathrm{J}, \mathrm{K}$ ) for commercial temperature range ( 0 to $+70^{\circ} \mathrm{C}$ ) applications, and one grade (S) rated for the $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ extended range. The AD536AK offers a maximum total error of $\pm 2 \mathrm{mV} \pm 0.2 \%$ of reading, and the AD536AJ and AD536AS have maximum errors of $\pm 5 \mathrm{mV} \pm 0.5 \%$ of reading. All three versions are available in either a hermetically sealed 14-pin DIP or 10-pin TO-100 metal can. The AD536AS is also available in a 20 -pin hermetically sealed ceramic leadless chip carrier.

## PIN CONFIGURATIONS AND FUNCTIONAL BLOCK DIAGRAMS



## PRODUCT HIGHLIGHTS

1. The AD536A computes the true root-mean-square level of a complex ac (or ac plus dc) input signal and gives an equivalent dc output level. The true rms value of a waveform is a more useful quantity than the average rectified value since it relates directly to the power of the signal. The rms value of a statistical signal also relates to its standard deviation.
2. The crest factor of a waveform is the ratio of the peak signal swing to the rms value. The crest factor compensation scheme of the AD536A allows measurement of highly complex signals with wide dynamic range.
3. The only external component required to perform measurements to the fully specified accuracy is the capacitor which sets the averaging period. The value of this capacitor determines the low frequency ac accuracy, ripple level and settling time.
4. The AD536A will operate equally well from split supplies or a single supply with total supply levels from 5 to 36 volts. The one milliampere quiescent supply current makes the device well-suited for a wide variety of remote controllers and battery powered instruments.
5. The AD536A directly replaces the AD536 and provides improved bandwidth and temperature drift specifications.

| Model | Min | $\begin{aligned} & \text { AD536A } \\ & \text { Typ } \end{aligned}$ | Max | Min | $\begin{gathered} \text { AD536A1 } \\ \text { Typ } \\ \hline \end{gathered}$ | Max | Min | $\begin{gathered} \text { AD536A } \\ \text { Typ } \\ \hline \end{gathered}$ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TRANSFER FUNCTION | $\mathrm{V}_{\text {OUT }}=\sqrt{\text { avg. }\left(\mathrm{V}_{\mathrm{IN}}\right)^{2}}$ |  |  | $\mathrm{V}_{\text {OUT }}=\sqrt{\text { avg. }\left(\mathrm{V}_{\text {IN }}\right)^{2}}$ |  |  | $\mathrm{V}_{\text {Out }}=\sqrt{\text { avg. }\left(\mathrm{V}_{\mathrm{IN}}\right)^{2}}$ |  |  |  |
| ```CONVERSIONACCURACY Total Error, Internal Trim \({ }^{1}\) (Figure 1) vs. Temperature, \(\mathrm{T}_{\text {min }}\) to \(+70^{\circ} \mathrm{C}\) \(+70^{\circ} \mathrm{C}\) to \(+125^{\circ} \mathrm{C}\) vs. Supply Voltage dc Reversal Error Total Error, External Trim \({ }^{1}\) (Figure 2)``` | $\begin{array}{ll}  & \pm 5 \pm 0.5 \\ & \pm 0.1 \pm 0.01 \\ & \\ \pm 0.1 \pm 0.01 \\ \pm 0.2 \\ \pm 3 \pm 0.3 \\ \hline \end{array}$ |  |  | $\begin{array}{ll}  & \pm 2 \pm 0.2 \\ & \pm 0.05 \pm 0.005 \\ & \\ \pm 0.1 \pm 0.01 \\ \pm 0.1 \\ \pm 2 \pm 0.1 & \end{array}$ |  |  | $\begin{aligned} & \quad \pm 5 \pm 0.5 \\ & \\ & \\ & \\ & \\ & \\ & \pm 0.1^{\prime} \pm 0.3 \pm 0.005 \\ & \pm 0.1 \pm 0.005 \end{aligned}$ |  |  | $\mathrm{mV} \pm \%$ of Reading <br> $\mathrm{mV} \pm \%$ of Reading ${ }^{\circ} \mathrm{C}$ <br> $\mathrm{mV} \pm \%$ of Reading $/ \mathrm{C}$ <br> $\mathrm{mV} \pm \%$ of Reading/V <br> $\pm \%$ of Reading <br> $\mathrm{m} \mathrm{V} \pm \%$ of Reading |
| ```ERRORVS.CRESTFACTOR }\mp@subsup{}{}{2 Crest Factor 1 to 2 Crest Factor = 3 Crest Factor = 7``` | $\begin{gathered} \text { Specified Accuracy } \\ -0.1 \\ -1.0 \end{gathered}$ |  |  | $\begin{gathered} \text { Specified Accuracy } \\ -0.1 \\ -1.0 \end{gathered}$ |  |  | $\begin{gathered} \text { Specified Accuracy } \\ -0.1 \\ -1.0 \end{gathered}$ |  |  | \%of Reading \% of Reading |
| ```FREQUENCY RESPONSE \({ }^{3}\) Bandwidth for \(1 \%\) additional error \((0.09 \mathrm{~dB})\) \(V_{\mathrm{IN}}=10 \mathrm{mV}\) \(\mathrm{V}_{\mathrm{IN}}=100 \mathrm{mV}\) \(\mathrm{V}_{\text {IN }}=1 \mathrm{~V}\) \(\pm 3 \mathrm{~dB}\) Bandwidth \(\mathrm{V}_{\text {IN }}=10 \mathrm{mV}\) \(\mathrm{V}_{\mathrm{IN}}=100 \mathrm{mV}\) \(V_{\text {IN }}=1 V\)``` |  | $\begin{aligned} & 5 \\ & 45 \\ & 120 \\ & 90 \\ & 450 \\ & 2.3 \end{aligned}$ |  |  | $\begin{aligned} & 5 \\ & 45 \\ & 120 \\ & 90 \\ & 950 \\ & 2.3 \end{aligned}$ |  |  | $\begin{aligned} & 5 \\ & 45 \\ & 120 \\ & 90 \\ & 90 \\ & 450 \\ & 2.3 \end{aligned}$ |  | $\mathbf{k H z}$ <br> kHz <br> kHz <br> $\mathbf{k H z}$ <br> kHz <br> MHz |
| AVERAGING TIMECONSTANT(Figure 5) |  | 25 |  |  | 25 |  |  | 25 |  | ms/ $/$ F CAV |
| INPUTCHARACTERISTICS <br> Signal Range, $\pm 15 \mathrm{~V}$ Supplies <br> Continuous rms Level <br> Peak Transient Input <br> Continuous rms Level, $\pm 5 \mathrm{~V}$ Supplies <br> Peak Transient Input, $\pm 5$ V Supplies <br> Maximum Continuous Nondestructive <br> Input Level (All Supply Voltages) <br> Input Resistance <br> Input Offset Voltage | 13.33 | 0 to 7 <br> 0 to 2 $\begin{aligned} & 16.67 \\ & 0.8 \\ & \hline \end{aligned}$ | $\begin{aligned} & \pm 20 \\ & \pm 7 \\ & \pm 25 \\ & 20 \\ & \pm 2 \end{aligned}$ | 13.33 | 0 to 7 <br> 0 to 2 $\begin{aligned} & 16.67 \\ & 0.5 \\ & \hline \end{aligned}$ | $\begin{aligned} & \pm 20 \\ & \pm 7 \\ & \pm 25 \\ & 20 \\ & \pm 1 \end{aligned}$ | 13.33 | $\begin{aligned} & 0 \text { to } 7 \\ & 0 \text { to } 2 \\ & \\ & 16.67 \\ & 0.8 \end{aligned}$ | $\begin{aligned} & \pm 20 \\ & \pm 7 \\ & \pm 25 \\ & 20 \\ & \pm 2 \end{aligned}$ | Vrms <br> $\checkmark$ peak <br> Vrms <br> $\checkmark$ peak <br> $\checkmark$ peak <br> k $\Omega$ <br> mV |
| ```OUTPUT CHARACTERISTICS Offset Voltage, \(\mathrm{V}_{\text {IN }}=\operatorname{COM}\) (Figure 1) vs. Temperature vs. Supply Voltage Voltage Swing, \(\pm 15 \mathrm{~V}\) Supplies \(\pm 5 \mathrm{~V}\) Supply``` | $\begin{aligned} & 0 \text { to }+11 \\ & 0 \text { to }+2 \end{aligned}$ | $\begin{aligned} & \pm 1 \\ & \pm 0.1 \\ & \pm 0.1 \\ & +12.5 \end{aligned}$ | $\pm 2$ | $\begin{aligned} & 0 \text { to }+11 \\ & 0 \text { to }+2 \end{aligned}$ | $\begin{aligned} & \pm 0.5 \\ & \pm 0.1 \\ & \pm 0.1 \\ & +12.5 \end{aligned}$ | $\pm 1$ | $\begin{aligned} & 0 \text { to }+1 \\ & 0 \text { to }+2 \end{aligned}$ |  | $\begin{aligned} & \pm 2 \\ & \pm 0.2 \end{aligned}$ | mV <br> $\mathrm{mV} /{ }^{\circ} \mathrm{C}$ <br> mV/V <br> V <br> V |
| dBOUTPUT(Figure 13) <br> Error, $\mathrm{V}_{\text {IN }} 7 \mathrm{mV}$ to 7 V rms, $0 \mathrm{~dB}=1 \mathrm{~V} \mathrm{rms}$ <br> Scale Factor <br> Scalc Factor TC(Uncompensated, see Figure I for Temperature Compensation) <br> $I_{\text {REF }}$ for $0 \mathrm{~dB} \quad 1 \mathrm{Vrms}$ $\mathrm{I}_{\text {Rep }}$ Range | $\begin{aligned} & 5 \\ & 1 \end{aligned}$ | $\begin{aligned} & \pm 0.4 \\ & -3 \\ & -0.03 \end{aligned}$ $20$ | $\begin{aligned} & \pm 0.6 \\ & 80 \\ & 100 \end{aligned}$ | 5 <br> 5 1 | $\begin{aligned} & \pm 0.2 \\ & -3 \\ & -0.03 \\ & +0.33 \\ & 20 \end{aligned}$ | $\pm 0.3$ $\begin{aligned} & 80 \\ & 100 \end{aligned}$ |  | $\begin{aligned} & \pm 0.5 \\ & -3 \\ & -0.03 \\ & +0.33 \\ & 20 \end{aligned}$ | $\begin{aligned} & \pm 0.6 \\ & 80 \\ & 100 \end{aligned}$ | dB <br> $\mathrm{mV} / \mathrm{dB}$ <br> $\mathrm{dB} /{ }^{\circ} \mathrm{C}$ <br> \% of Reading ${ }^{\circ} \mathrm{C}$ <br> $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ |
| Iout TERMINAL I our Scale Finc tor $\mathrm{I}_{\text {OÜ̈r }}$ Scale Factor Tolerance Output Resistance Voltage Compliance | $20$ | $\begin{aligned} & 40 \\ & \pm 10 \\ & 25 \\ & -V_{s} t 0 \\ & -2.5 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & \pm 20 \\ & 30 \end{aligned}$ | 20 | $\begin{aligned} & 40 \\ & \pm 10 \\ & 25 \\ & -V_{s} t c \\ & -2.5) \end{aligned}$ | $\begin{aligned} & \pm 20 \\ & 30 \end{aligned}$ | $20$ | $\begin{aligned} & 40 \\ & \pm 10 \\ & 25 \\ & -V_{s t c} \\ & -2.5 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & \pm 20 \\ & 30 \end{aligned}$ | $\mu \mathrm{A} / \mathrm{V}$ rms <br> \% <br> $\mathrm{k} \Omega$ <br> V |
| BUFFER AMPI.IFIER <br> Input and Output Voltage Range <br> Input Offset Voltage, $\mathrm{R}_{\mathbf{S}}=\mathbf{2 5} \mathbf{k}$ <br> Input Bias Current <br> Input Resistance <br> Output Current <br> Short Circuit Current <br> Output Resistance <br> Small Signal Bandwidth <br> Slew Rate ${ }^{4}$ | $\begin{aligned} & -\mathrm{V}_{\mathrm{s} \text { to }(+} \\ & -2.5 \mathrm{~V}) \\ & \\ & (+5 \mathrm{~mA}, \\ & -130 \mu \mathrm{~A}) \end{aligned}$ | $\begin{aligned} & \pm 0.5 \\ & 20 \\ & 10^{8} \end{aligned}$ <br> 20 1 5 | $\begin{aligned} & \pm 4 \\ & 60 \end{aligned}$ $0.5$ | $\begin{aligned} & (+5 \mathrm{~mA}, \\ & -130 \mu \mathrm{~A}) \end{aligned}$ | $\begin{aligned} & \pm 0.5 \\ & 20 \\ & 10^{8} \end{aligned}$ <br> 20 1 5 | $0.5$ | $\begin{aligned} & -V_{s} \text { to } \\ & -2.5 \mathrm{~V}) \end{aligned}$ | $\begin{aligned} & \pm 0.5 \\ & 20 \\ & 10^{8} \end{aligned}$ <br> 20 1 5 | $\begin{aligned} & \pm 4 \\ & 60 \end{aligned}$ $0.5$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{mV} \\ & \mathrm{nA} \\ & \Omega \end{aligned}$ |
|  | $\begin{aligned} & \pm 3.0 \\ & +5 \end{aligned}$ | $\pm 15$ $1.2$ | $\begin{aligned} & \pm 18 \\ & +36 \\ & 2 \end{aligned}$ | $\begin{aligned} & \pm 3.0 \\ & +5 \end{aligned}$ | $\pm 15$ $1.2$ | $\begin{aligned} & \pm 18 \\ & +36 \\ & 2 \end{aligned}$ | $\begin{aligned} & \pm 3.0 \\ & +5 \end{aligned}$ | $\pm 15$ $1.2$ | $\begin{aligned} & \pm 18 \\ & +36 \\ & 2 \end{aligned}$ | V <br> $\stackrel{\rightharpoonup}{v}$ <br> mA |
| TEMPERATURERANGE Rated Performance | 0 |  | $+70$ | 0 |  | +70 | -55 |  | +125 | ${ }^{\circ} \mathrm{C}$ |
| NUMBER OF TRANSISTORS | 65 |  |  | 65 |  |  | 65 |  |  |  |

## NOTES

${ }^{1}$ Accuracy is specified for 0 to 7 V rms, dc or 1 kHz sinewave input with the AD536A connected as in the figure referenced.
${ }^{2}$ Error vs. crest factor is specified as an additional error for 1 V rms rectangular pulse input, pulse width $=200 \mu \mathrm{~s}$.
${ }^{3}$ Input voltages are expressed in volts rms, and error is percent of reading
${ }^{4}$ With 2 k external pulldown resistor.
Specifications subject to change without notice.

Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All $\min$ and max specifications are guaranteed, although only those shown in boldface are tested on all production units.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$



## CHIP DIMENSIONS AND PAD LAYOUT

Dimensions shown in inches and (mm).


ORDERING GUIDE

|  | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| Model ${ }^{1}$ |  |  |  |

[^244]
## STANDARD CONNECTION

The AD536A is simple to connect for the majority of high accuracy rms measurements, requiring only an external capacitor to set the averaging time constant. The standard connection is shown in Figure 1. In this configuration, the AD536A will measure the rms of the ac and dc level present at the input, but will show an error for low frequency inputs as a function of the filter capacitor, $C_{A v}$, as shown in Figure 5. Thus, if a $4 \mu \mathrm{~F}$ capacitor is used, the additional average error at 10 Hz will be $0.1 \%$; at 3 Hz it will be $1 \%$. The accuracy at higher frequencies will be according to specification. If it is desired to reject the dc input, a capacitor is added in series with the input, as shown in Figure 3 , the capacitor must be nonpolar. If the AD536A is driven with power supplies with a considerable amount of high frequency ripple, it is advisable to bypass both supplies to ground with $0.1 \mu \mathrm{~F}$ ceramic discs as near the device as possible.


Figure 1. Standard RMS Connection

FEATURES
True rms-to-dc Conversion
200 mV Full Scale
Laser-Trimmed to High Accuracy
0.5\% max Error (AD636K)
1.0\% max Error (AD636J)

Wide Response Capability:
Computes rms of ac and dc Signals
1 MHz -3dB Bandwidth: $\mathrm{V}_{\text {rms }}>100 \mathrm{mV}$
Signal Crest Factor of 6 for 0.5\% Error
dB Output with 50 dB Range
Low Power: $\mathbf{8 0 0} \mu \mathrm{A}$ Quiescent Current
Single or Dual Supply Operation
Monolithic Integrated Circuit
Low Cost
Available in Chip Form

PIN CONNECTIONS \& FUNCTIONAL BLOCK DIAGRAM

"H" Package
(TO-100)

is accurate within $\pm 0.2 \mathrm{mV}$ to $\pm 0.03 \%$ of reading. Both versions are specified for the 0 to $+70^{\circ} \mathrm{C}$ temperature range, and are offered in either a hermetically sealed 14 -pin DIP or a 10 -pin TO-100 metal can. Chips are also available.

## PRODUCT HIGHLIGHTS

1. The AD636 computes the true root-mean-square of a complex ac (or ac plus dc) input signal and gives an equivalent dc output level. The true rms value of a waveform is a more useful quantity than the average rectified value since it is a measure of the power in the signal. The rms value of an ac-coupled signal is also its standard deviation.
2. The $\mathbf{2 0 0}$ millivolt full scale range of the AD636 is compatible with many popular display-oriented analog-to-digital converters. The low power supply current requirement permits use in battery-powered hand-held instruments.
3. The only external component required to perform measurements to the fully specified accuracy is the averaging capacitor. The value of this capacitor can be selected for the desired trade-off of low frequency accuracy, ripple, and settling time.
4. The on-chip buffer amplifier can be used to buffer either the input or the output. Used as an input buffer, it provides accurate performance from standard $10 \mathrm{M} \Omega$ input attenuators. As an output buffer, it can supply up to 5 milliamps of output current.
5. The AD636 will operate over a wide range of power supply voltages, including single +5 V to +24 V or split $\pm 2.5 \mathrm{~V}$ to $\pm 16.5 \mathrm{~V}$ sources. A standard 9 V battery will provide several hundred hours of continuous operation.

[^245]


## NOTES

${ }^{1}$ Accuracy specified for 0 to 200 mV rms, dc or 1 kHz sinewave input. Accuracy is degraded at higher rms signal levels.
${ }^{2}$ Measured at pin 8 of $\operatorname{DIP}\left(I_{O U T}\right)$, with pin 9 tied to common.
${ }^{3}$ Error vs. crest factor is specified as additional error for a 200 mV rms rectangular pulse train, pulse width $=200 \mu \mathrm{~s}$.
${ }^{4}$ Input voltages are expressed in volts rms.
${ }^{5}$ With $10 \mathrm{k} \Omega$ pull down resistor from pin 6 (BUF OUT) to $-V_{S}$.
${ }^{6}$ With BUF input tied to Common.
Specifications subject to change without notice.
All min and max specifications are guaranteed. Specifications shown in
boldface are tested on all production units at final electrical test are used to calculate outgoing quality levels.

| ABSOLUTE MAXIMUM RATINGS ${ }^{1}$ |  |
| :---: | :---: |
| Supply Voltage |  |
| Dual Supply | $\pm 16.5$ |
| Single Supply | +24 V |
| Internal Power Dissipation ${ }^{2}$ | 500 mW |
| Maximum Input Voltage . . . . . . . . . . . . . . . . $\pm 12 \mathrm{~V}$ Peak |  |
| Storage Temperature Range $\ldots . . . . . . . .-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |  |
| Operating Temperature Range |  |
| AD636J/K | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ |
| Lead Temperature Range (Soldering 60 sec ) | $+300^{\circ} \mathrm{C}$ |
| ESD Rating |  |

## NOTES

'Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation ofthe device at these or anyother conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2} 10$-Pin Header: $\theta_{\mathrm{JA}}=150^{\circ} \mathrm{C} / \mathrm{W}$.
$14-$ Pin Sidebrazed Ceramic DIP: $\theta_{\mathrm{JA}}=95^{\circ} \mathrm{C} / \mathrm{W}$.

## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD636JD | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Side Brazed Ceramic DIP | D-14 |
| AD636KD | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Side Brazed Ceramic DIP | D-14 |
| AD636JH | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Header | H-10A |
| AD636KH | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Header | $\mathrm{H}-10 \mathrm{~A}$ |
| AD636J Chip | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Chip |  |
| AD636K Chip | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Chip |  |

*For outline information see Package Information section.

## METALIZATION PHOTOGRAPH

Dimensions shown in inches and (mm).


FEATURES<br>High Accuracy<br>0.02\% Max Nonlinearity, 0 to 2V RMS Input<br>0.10\% Additional Error to Crest Factor of 3<br>Wide Bandwidth<br>$\mathbf{8 M H z}$ at 1 V RMS Input<br>600 kHz at 100 mV RMS<br>Computes:<br>True RMS<br>Square<br>Mean Square<br>Absolute Value<br>dB Output (60dB Range)<br>Chip Select-Power Down Feature Allows: Analog "3-State" Operation<br>Quiescent Current Reduction from 2.2 mA to $350 \mu \mathrm{~A}$<br>Side Brazed DIP, Low-Cost Cerdip and SOIC

## PRODUCT DESCRIPTION

The AD637 is a complete high accuracy monolithic rms to dc converter that computes the true rms value of any complex waveform. It offers performance that is unprecedented in integrated circuit rms to dc converters and comparable to discrete and modular techniques in accuracy, bandwidth and dynamic range. A crest factor compensation scheme in the AD637 permits measurements of signals with crest factors of up to 10 with less than $1 \%$ additional error. The circuit's wide bandwidth permits the measurement of signals up to 600 kHz with inputs of 200 mV rms and up to 8 MHz when the input levels are above 1 V rms.
As with previous monolithic rms converters from Analog Devices, the AD637 has an auxiliary dB output available to the user. The logarithm of the rms output signal is brought out to a separate pin allowing direct dB measurement with a useful range of 60 dB . An externally programmed reference current allows the user to select the 0 dB reference voltage to correspond to any level between 0.1 V and 2.0 V rms.

A chip select connection on the AD637 permits the user to decrease the supply current from 2.2 mA to $350 \mu \mathrm{~A}$ during periods when the rms function is not in use. This feature facilitates the
addition of precision rms measurement to remote or hand-held applications where minimum power consumption is critical. In addition when the AD637 is powered down the output goes to a high impedance state. This allows several AD637s to be tied together to form a wide-band true rms multiplexer.
The input circuitry of the AD637 is protected from overload voltages that are in excess of the supply levels. The inputs will not be damaged by input signals if the supply voltages are lost.
The AD637 is available in two accuracy grades (J, K) for commercial ( 0 to $+70^{\circ} \mathrm{C}$ ) temperature range applications; two accuracy grades (A, B) for industrial $\left(-40^{\circ} \mathrm{C}\right.$ to $\left.+85^{\circ} \mathrm{C}\right)$ applications; and one (S) rated over the $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ temperature range. All versions are available in hermetically-sealed, 14 -pin sidebrazed ceramic DIPs as well as low-cost cerdip packages. A 16-pin SOIC package is also available.

## PRODUCT HIGHLIGHTS

1. The AD637 computes the true root-mean-square, mean square, or absolute value of any complex ac (or ac plus dc) input waveform and gives an equivalent dc output voltage. The true rms value of a waveform is more useful than an average rectified signal since it relates directly to the power of the signal. The rms value of a statistical signal is also related to the standard deviation of the signal.
2. The AD637 is laser wafer trimmed to achieve rated performance without external trimming. The only external component required is a capacitor which sets the averaging time period. The value of this capacitor also determines low frequency accuracy, ripple level and settling time.
3. The chip select feature of the AD637 permits the user to power down the device down during periods of nonuse, thereby, decreasing battery drain in remote or hand-held applications.
4. The on-chip buffer amplifier can be used as either an input buffer or in an active filter configuration. The filter can be used to reduce the amount of ac ripple, thereby, increasing the accuracy of the measurement.
[^246]AD637
-SPECIFICATIONS
(@ $+25^{\circ} \mathrm{C}$, and $\pm 15 \mathrm{~V}$ dc unless otherwise noted.)

| Model | Min | $\begin{aligned} & \text { AD637J/ } \\ & \text { Typ } \end{aligned}$ | Max | Min | $\begin{aligned} & \text { D637K/ } \\ & \text { Typ } \end{aligned}$ | Max | Min | $\begin{aligned} & \text { DD637 } \\ & \text { Typ } \\ & \hline \end{aligned}$ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TRANSFER FUNCTION | $\mathrm{V}_{\text {OUT }}=\sqrt{\text { avg. }\left(\mathrm{V}_{\text {IN }}\right)^{2}}$ |  |  | $\mathrm{V}_{\text {OUT }}=\sqrt{\text { avg. }\left(\mathrm{V}_{\text {IN }}\right)^{2}}$ |  |  | $\mathrm{V}_{\text {OuT }}=\sqrt{\text { avgo }{ }_{\text {¢ }}\left(\mathrm{V}_{\text {IN }}\right)^{2}}$ |  |  |  |
| CONVERSION ACCURACY <br> Total Error, Internal Trim ${ }^{1}$ (Fig. 2) $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ <br> vs. Supply, $+V_{\mathbf{I N}}=+300 \mathrm{mV}$ <br> vs. Supply, $-V_{\mathbf{I N}^{\prime}}=-\mathbf{3 0 0 m V}$ <br> dc Reversal Error at 2V <br> Nonlinearity 2V Full Scale ${ }^{2}$ <br> Nonlinearity 7V Full Scale <br> Total Error, External Trim |  | 30 <br> 100 $\pm 0.5=$ | $\begin{aligned} & \pm 1 \pm 0.5 \\ & \pm 3.0 \pm 0.6 \\ & 150 \\ & 300 \\ & 0.25 \\ & 0.04 \\ & 0.05 \end{aligned}$ |  | 30 <br> 100 $\pm 0.25$ | $\begin{aligned} & \pm 0.5 \pm 0.2 \\ & \pm 2.0 \pm 0.3 \\ & 150 \\ & 300 \\ & 0.1 \\ & 0.02 \\ & 0.05 \end{aligned}$ |  | 30 <br> 100 $\pm 0.5$ | $\begin{aligned} & \pm 1 \pm 0.5 \\ & \pm 6 \pm 0.7 \\ & 150 \\ & 300 \\ & 0.25 \\ & 0.04 \\ & 0.05 \end{aligned}$ | $\begin{aligned} & \mathrm{mV} \pm \% \text { of Reading } \\ & \mathrm{mV} \pm \% \text { of Reading } \\ & \mu \mathrm{V} / \mathrm{V} \\ & \mu \mathrm{~V} / \mathrm{V} \\ & \% \text { of Reading } \\ & \% \text { of FSR } \\ & \% \text { of FSR } \\ & \mathrm{mV} \pm \% \text { of Reading } \end{aligned}$ |
| ```ERRORVS.CRESTFACTOR \({ }^{3}\) Crest Factor 1 to 2 Crest Factor \(=3\) Crest Factor \(=10\) AVERAGING TIMECONSTANT``` | $\begin{gathered} \text { Specified Accuracy } \\ \pm 0.1 \\ \pm 1.0 \\ 25 \end{gathered}$ |  |  | $\begin{gathered} \text { Specified Accuracy } \\ \pm 0.1 \\ \pm 1.0 \\ 25 \end{gathered}$ |  |  | $\begin{gathered} \text { Specified Accuracy } \\ \pm 0.1 \\ \pm 1.0 \\ 25 \end{gathered}$ |  |  | \% of Reading \% of Reading $\mathrm{ms} / \mu \mathrm{FC}_{\mathrm{Av}}$ |
| INPUTCHARACTERISTICS <br> Signal Range, $\pm 15 \mathrm{~V}$ Supply <br> Continuous rms Level <br> Peak Transient Input <br> Signal Range, $\pm 5$ V Supply <br> Continuous rms Level <br> Peak Transient Input <br> Maximum Continuous Non-Destructive Input Level(All Supply Voltages) <br> Input Resistance <br> Input Offset Voltage | 6.4 | $\begin{aligned} & 0 \text { to } 7 \\ & 0 \text { to } 4 \\ & 8 \end{aligned}$ | $\begin{aligned} & \pm 15 \\ & \pm 6 \\ & \pm 15 \\ & 9.6 \\ & \pm 0.5 \end{aligned}$ | 6.4 | 0 to 7 <br> 0to 4 | $\begin{aligned} & \pm 15 \\ & \pm 6 \\ & \pm 15 \\ & 9.6 \\ & \pm 0.2 \end{aligned}$ | 6.4 | 0 to 7 $00 t o 4$ | $\begin{aligned} & \pm 15 \\ & \pm 6 \\ & \pm 15 \\ & 9.6 \\ & \pm 0.5 \end{aligned}$ | Vrms <br> Vp-p <br> Vrms <br> Vp-p <br> Vp-p <br> $\mathrm{k} \Omega$ <br> mV |
| ```FREQUENCY RESPONSE \({ }^{4}\) Bandwidth for \(1 \%\) additional error ( 0.09 d \(\mathrm{V}_{\mathrm{IN}}=20 \mathrm{mV}\) \(\mathrm{V}_{\mathrm{IN}}=200 \mathrm{mV}\) \(\mathrm{V}_{\mathrm{in}}=2 \mathrm{~V}\) \(\pm\) 3dB Bandwidth \(\mathrm{V}_{\mathrm{IN}}=20 \mathrm{mV}\) \(V_{\text {IN }}=200 \mathrm{mV}\) \(\mathrm{V}_{\mathrm{IN}}=2 \mathrm{~V}\)``` |  | $\begin{aligned} & 11 \\ & 66 \\ & 200 \\ & 150 \\ & 1 \\ & 8 \end{aligned}$ |  |  | $\begin{aligned} & 11 \\ & 66 \\ & 200 \\ & 150 \\ & 1 \\ & 8 \end{aligned}$ |  |  | $\begin{aligned} & 11 \\ & 66 \\ & 200 \\ & 150 \\ & 1 \\ & 8 \end{aligned}$ |  | $\mathbf{k H z}$ <br> kHz <br> kHz <br> $\mathbf{k H z}$ <br> MHz <br> MHz |
| OUTPUTCHARACTERISTICS <br> Offset Voltage <br> vs. Temperature <br> Voltage Swing, $\pm 15 \mathrm{~V}$ Supply, $2 \mathrm{k} \Omega$ Load <br> Voltage Swing, $\pm 3 V$ Supply, $2 \mathrm{k} \Omega$ Load <br> Output Current <br> Short Circuit Current <br> Resistance, Chip Select "High" <br> Resistance, ChipSelect "Low" | $\begin{aligned} & 0 \text { to }+12.0 \\ & 0 \text { to }+2 \\ & 6 \end{aligned}$ | $\begin{aligned} & \pm 0.05 \\ & +13.5 \\ & +2.2 \\ & 20 \\ & 0.5 \\ & 100 \end{aligned}$ | $\begin{aligned} & \pm 1 \\ & \pm 0.089 \end{aligned}$ | $\begin{aligned} & 0 \text { to }+12.0 \\ & 0 \text { to }+2 \\ & 6 \end{aligned}$ | $\begin{aligned} & \pm 0.04 \\ & +13.5 \\ & +2.2 \\ & 20 \\ & 0.5 \\ & 100 \end{aligned}$ | $\begin{aligned} & \pm 0.5 \\ & \pm 0.056 \end{aligned}$ | $\begin{aligned} & 0 \text { to }+12.0 \\ & 0 \text { to }+2 \\ & 6 \end{aligned}$ | $\begin{aligned} & \pm 0.04 \\ & +13.5 \\ & +2.2 \\ & 20 \\ & 0.5 \\ & 100 \end{aligned}$ | $\begin{aligned} & \pm 1 \\ & \pm 0.07 \end{aligned}$ | mV <br> $\mathrm{mV} /{ }^{\circ} \mathrm{C}$ <br> v <br> v <br> mA <br> mA <br> $\Omega$ <br> $\mathrm{k} \Omega$ |
| dB OUTPUT <br> Error, $\mathrm{V}_{\mathrm{IN}} 7 \mathrm{mV}$ to 7 V rms, $\mathbf{0 d B}=1 \mathrm{~V}$ rm <br> Scale Factor <br> Scale Factor Temperature Coefficient <br> $\mathrm{I}_{\text {REF }}$ for $0 \mathrm{~dB}=1 \mathrm{~V}$ rms <br> $I_{\text {REF }}$ Range | $\begin{aligned} & 5 \\ & 1 \end{aligned}$ | $\begin{aligned} & \pm 0.5 \\ & -3 \\ & +0.33 \\ & -0.03 \\ & 20 \end{aligned}$ | $\begin{aligned} & 80 \\ & 100 \end{aligned}$ | $\begin{aligned} & 5 \\ & 1 \end{aligned}$ | $\begin{aligned} & \pm 0.3 \\ & -3 \\ & +0.33 \\ & -0.03 \\ & 20 \end{aligned}$ | $\begin{aligned} & 80 \\ & 100 \end{aligned}$ | $\begin{aligned} & 5 \\ & 1 \end{aligned}$ | $\begin{aligned} & \pm 0.5 \\ & -3 \\ & +0.33 \\ & -0.03 \\ & 20 \end{aligned}$ | $\begin{aligned} & 80 \\ & 100 \end{aligned}$ | dB <br> $\mathrm{mV} / \mathrm{dB}$ <br> \%of Reading ${ } / \mathrm{C}$ <br> $\mathrm{dB} /{ }^{\circ} \mathrm{C}$ <br> $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ |
| BUFFER AMPLIFIER <br> Input and Output Voltage Range <br> Input Offset Voltage <br> Input Current <br> Input Resistance <br> Output Current <br> Short Circuit Current <br> Small Signal Bandwidth Slew Rate ${ }^{5}$ | $\begin{aligned} & -V_{s} \text { to( } \\ & -2.5 \mathrm{~V}) \end{aligned}$ $\begin{gathered} (+5 \mathrm{~mA}, \\ -130 \mu \mathrm{~A}) \end{gathered}$ | $\begin{aligned} & \pm 0.8 \\ & \pm 2 \\ & 10^{8} \end{aligned}$ <br> 20 <br> 1 5 | $\begin{aligned} & \pm 2 \\ & \pm 10 \end{aligned}$ | $\begin{aligned} & -V_{\text {sto }}(+ \\ & -2.5 V) \end{aligned}$ $\begin{gathered} (+5 \mathrm{~mA} \\ -130 \mu \mathrm{~A}) \end{gathered}$ | $\begin{aligned} & \pm 0.5 \\ & \pm 2 \\ & 10^{8} \\ & \\ & 20 \\ & 1 \\ & 5 \end{aligned}$ | $\begin{aligned} & \pm 1 \\ & \pm 5 \end{aligned}$ | $\begin{aligned} & -V_{s} \text { to }(+ \\ & -2.5 \mathrm{~V}) \end{aligned}$ $\begin{aligned} & (+5 m \mathrm{~A}, \\ & -130 \mu \mathrm{~A}) \end{aligned}$ | $\begin{aligned} & \pm 0.8 \\ & \pm 2 \\ & 10^{8} \\ & \\ & 20 \\ & 1 \\ & 5 \end{aligned}$ | $\begin{aligned} & \pm 2 \\ & \pm 10 \end{aligned}$ | v <br> mV <br> nA <br> $\boldsymbol{\Omega}$ <br> mA <br> MHz <br> V/us |
| DENOMINATOR INPUT Input Range Input Resistance Offset Voltage | 20 | $\begin{aligned} & 0 \text { to }+ \\ & 25 \\ & \pm 0.2 \end{aligned}$ | $\begin{aligned} & 30 \\ & \pm 0.5 \end{aligned}$ | 20 | $\begin{aligned} & \text { 0to }+ \\ & 25 \\ & \pm 0.2 \end{aligned}$ | $\begin{aligned} & 30 \\ & \pm 0.5 \end{aligned}$ | 20 | $\begin{aligned} & 0 \text { to }+ \\ & 25 \\ & \pm 0.2 \end{aligned}$ | $\begin{aligned} & 30 \\ & \pm 0.5 \end{aligned}$ | $\begin{aligned} & \mathbf{V} \\ & \mathbf{k} \Omega \\ & \mathrm{mV} \end{aligned}$ |
| ```CHIP SELECT PROVISION(CS) rms "ON" Level rms "OFF" Level Iout of Chip Select CS"LOW" CS "HIGH" On TimeConstant Off Time Constant``` | $\begin{aligned} & \text { Open or }+2.4 \mathrm{~V}<\mathrm{V}_{\mathbf{C}}<+\mathrm{V}_{\mathbf{S}} \\ & \mathrm{V}_{\mathrm{C}}<+0.2 \mathrm{~V} \\ & 10 \\ & 10 \\ & \text { Zero } \\ & 10 \mu \mathrm{~S}+\left((25 \mathrm{KK} \Omega) \times \mathrm{C}_{\mathrm{AV}}\right) \\ & 10 \mu \mathrm{~s}+\left((25 \mathrm{k} \Omega) \times \mathrm{C}_{\mathrm{AV}}\right) \end{aligned}$ |  |  | $\begin{aligned} & \text { Open or }+2.4 \mathrm{~V}<\mathrm{V}_{\mathrm{C}}<+\mathrm{V}_{\mathrm{s}} \\ & \mathrm{~V}_{\mathrm{c}}<+0.2 \mathrm{~V} \\ & 10 \\ & 10 \\ & \text { Zero } \\ & 10 \mu \mathrm{~s}+\left((25 \mathrm{k} \Omega) \times \mathrm{C}_{\mathrm{Av}}\right) \\ & 10 \mu \mathrm{~s}+\left((25 \mathrm{k} \Omega) \times \mathrm{C}_{\mathrm{AV}}\right) \\ & \hline \end{aligned}$ |  |  | $\begin{aligned} & \text { Open or }+2.4 \mathrm{~V}<\mathrm{V}_{\mathbf{C}}<+\mathrm{V}_{\mathbf{S}} \\ & \mathrm{V}_{\mathbf{C}}<+0.2 \mathrm{~V} \\ & 10 \\ & 10 \\ & \text { Zero } \\ & 10 \mu \mathrm{~s}+\left((25 \mathrm{k} \Omega) \times \mathrm{C}_{\boldsymbol{A V}}\right) \\ & 10 \mu \mathrm{~s}+\left((25 \mathrm{k} \Omega) \times \mathrm{C}_{\boldsymbol{A v}}\right) \end{aligned}$ |  |  | $\mu \mathrm{A}$ |
| POWER SUPPLY Operating Voltage Range Quiescent Current Standby Current | $\pm 3.0$ | $\begin{aligned} & 2.2 \\ & 350 \end{aligned}$ | $\begin{aligned} & \pm 18 \\ & 3 \\ & 450 \end{aligned}$ | $\pm 3.0$ | $\begin{aligned} & 2.2 \\ & 350 \end{aligned}$ | $\begin{aligned} & \pm 18 \\ & 3 \\ & 450 \end{aligned}$ | $\pm 3.0$ | $\begin{aligned} & 2.2 \\ & 350 \end{aligned}$ | $\begin{aligned} & \pm 18 \\ & 3 \\ & 450 \end{aligned}$ | $\begin{aligned} & \mathbf{V} \\ & \mathrm{mA} \\ & \mu \mathrm{~A} \end{aligned}$ |


|  | AD637J/A |  |  | AD637K/B |  |  | AD637S |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Model | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| TRANSISTOR COUNT | 107 |  |  | 107 |  |  | 107 |  |  |  |

NOTES
${ }^{1}$ Accuracy specified $0-7 \mathrm{~V}$ rms de with AD637 connected as shown in Figure 2.
${ }^{2}$ Nonlinearity is defined as the maximum deviation from the straight line connecting the readings at 10 mV and 2 V
${ }^{3}$ Error vs. crest factor is specified as additional error for 1 V rms.
${ }_{5}^{4}$ Input voltages are expressed in volts rms. \% are in \% of reading.
${ }^{5}$ With external $2 \mathrm{k} \Omega$ pull down resistor tied to $-\mathrm{V}_{\mathrm{s}}$.
Specifications subject tochange without notice.
Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to caiculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.

## ABSOLUTE MAXIMUM RATINGS

| ESD Rating | 0 V |
| :---: | :---: |
| Supply Voltage | $\pm 18 \mathrm{~V}$ dc |
| Internal Quiescent Power Dissipation | 108 mW |
| Output Short-Circuit Duration | Indefinite |
| Storage Temperature Range | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Lead Temperature Range (Soldering 10 sec ) | $+300^{\circ} \mathrm{C}$ |
| Rated Operating Temperature Range |  |
| AD637J, K | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ |
| AD637A, B | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| AD637S, 5962-8963701CA | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |

ORDERING GUIDE

| Model ${ }^{1,2}$ | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD637AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | SOIC | R-16 |
| AD637BR | $-40^{\circ} \mathrm{C}$ t $+85^{\circ} \mathrm{C}$ | SOIC | R-16 |
| AD637AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Cerdip | Q-14 |
| AD637BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Cerdip | R-14 |
| AD637JR-Reel | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | SOIC | R |
| AD637JD | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Side Brazed Ceramic DIP | D-14 |
| AD637KD | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Side Brazed Ceramic DIP | D-14 |
| AD637JQ | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Cerdip | Q-14 |
| AD637KQ | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Cerdip | Q-14 |
| AD637JR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | SOIC | R-16 |
| AD637SD | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Side Brazed Ceramic DIP | D-14 |
| AD637SD/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Side Brazed Ceramic DIP | D-14 |
| AD637SQ/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Cerdip | Q-14 |

## NOTES

1" J " and " S " grade chips are also available.
${ }^{2}$ A Standard Military Drawing, 5962-89637, is also available.
${ }^{3}$ For outline information see Package Information section.

CHIP DIMENSIONS AND BONDING DIAGRAM Dimensions shown in inches and (mm).


## PIN CONFIGURATIONS



NC $=$ NO CONNECT

## FEATURES <br> COMPUTES

True RMS Value
Average Rectified Value
Absolute Value
PROVIDES
200mV Full-Scale Input Range (Larger Inputs with Input Attenuator)
High Input Impedance of $10^{12} \Omega$
Low Input Bias Current: 25pA max
High Accuracy: $\pm 0.3 \mathrm{mV} \pm 0.3 \%$ of Reading
RMS Conversion with Signal Crest Factors Up to 5
Wide Power Supply Range: $+\mathbf{2 . 8 V}, \mathbf{- 3 . 2 V}$
to $\pm 16.5 \mathrm{~V}$
Low Power: 200~A max Supply Current
Buffered Voltage Output
No External Trims Needed for Specified Accuracy
AD737-An Unbuffered Voltage Output Version with Chip Power Down Is Also Available

## PRODUCT DESCRIPTION

The AD736 is a low power, precision, monolithic true rms-to-dc converter. It is laser trimmed to provide a maximum error of $\pm 0.3 \mathrm{mV} \pm 0.3 \%$ of reading with sine-wave inputs. Furthermore, it maintains high accuracy while measuring a wide range of input waveforms, including variable duty cycle pulses and triac (phase) controlled sine waves. The low cost and small physical size of this converter make it suitable for upgrading the performance of non-rms "precision rectifiers" in many applications. Compared to these circuits, the AD736 offers higher accuracy at equal or lower cost.
The AD736 can compute the rms value of both ac and dc input voltages. It can also be operated ac coupled by adding one external capacitor. In this mode, the AD736 can resolve input signal levels of $100 \mu \mathrm{~V}$ rms or less, despite variations in temperature or supply voltage. High acccuracy is also maintained for input waveforms with crest factors of 1 to 3 . In addition, crest factors as high as 5 can be measured (while introducing only $2.5 \%$ additional error) at the 200 mV full-scale input level.
The AD736 has its own output buffer amplifier, thereby providing a great deal of design flexibility. Requiring only $200 \mu \mathrm{~A}$ of power supply current, the AD736 is optimized for use in portable multimeters and other battery powered applications.
The AD736 allows the choice of two signal input terminals: a high impedance ( $10^{12} \Omega$ ) FET input which will directly interface with high $Z$ input attenuators and a low impedance ( $8 \mathrm{k} \Omega$ ) input

FUNCTIONAL BLOCK DIAGRAM

which allows the measurement of 300 mV input levels, while operating from the minimum power supply voltage of +2.8 V , -3.2 V . The two inputs may be used either singly or differentially.
The AD736 achieves a $1 \%$ of reading error bandwidth exceeding 10 kHz for input amplitudes from 20 mV rms to 200 mV rms while consuming only 1 mW .
The AD736 is available in four performance grades. The AD736J and AD736K grades are rated over the commercial temperature range of 0 to $+70^{\circ} \mathrm{C}$. The AD736A and AD736B grades are rated over the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.
The AD736 is available in three low-cost 8-pin packages: plastic mini-DIP, plastic SO and hermetic cerdip.

## PRODUCT HIGHLIGHTS

1. The AD736 is capable of computing the average rectified value, absolute value or true rms value of various input signals.
2. Only one external component, an averaging capacitor, is required for the AD736 to perform true rms measurement.
3. The low power consumption of 1 mW makes the AD736 suitable for many battery powered applications.
4. A high input impedance of $10^{12} \Omega$ eliminates the need for an external buffer when interfacing with input attenuators.
5. A low impedance input is available for those applications requiring up to 300 mV rms input signal operating from low power supply voltages.

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|  |  |  | 736J/A |  |  | 736K |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Model | Conditions | Min | Typ | Max | Min | Typ | Max | Units |
| FREQUENCY RESPONSE <br> Low Impedance Input (Pin 1) |  |  |  |  |  |  |  |  |
| For 1\% Additional Error | Sine-Wave Input |  |  |  |  |  |  |  |
| $\mathrm{V}_{\text {IN }}=1 \mathrm{mV}$ rms |  |  | 1 |  |  | 1 |  | kHz |
| $\mathrm{V}_{\text {IN }}=10 \mathrm{mV}$ rms |  |  | 6 |  |  | 6 |  | kHz |
| $\mathrm{V}_{\text {IN }}=100 \mathrm{mV} \mathrm{rms}$ |  |  | 90 |  |  | 90 |  | kHz |
| $\mathrm{V}_{\text {IN }}=200 \mathrm{mV} \mathrm{rms}$ |  |  | 90 |  |  | 90 |  | kHz |
| $\pm 3 \mathrm{~dB}$ Bandwidth | Sine-Wave Input |  |  |  |  |  |  |  |
| $\mathrm{V}_{\text {IN }}=1 \mathrm{mV} \mathrm{rms}$ |  |  | 5 |  |  | 5 |  | kHz |
| $\mathrm{V}_{\text {IN }}=10 \mathrm{mV} \mathrm{rms}$ |  |  | 55 |  |  | 55 |  | kHz |
| $\mathrm{V}_{\text {IN }}=100 \mathrm{mV} \mathrm{rms}$ |  |  | 350 |  |  | 350 |  | kHz |
| $\mathrm{V}_{\text {IN }}=200 \mathrm{mV} \mathrm{rms}$ |  |  | 460 |  |  | 460 |  | kHz |
| POWER SUPPLY |  |  |  |  |  |  |  |  |
| Operating Voltage Range |  | +2.8, - 3.2 | $\pm 5$ | $\pm 16.5$ | +2.8, - 3.2 |  | $\pm 16.5$ | Volts |
| Quiescent Current | Zero Signal |  | 160 | 200 |  | 160 | 200 | $\mu \mathrm{A}$ |
| 200 mV rms, No Load | Sine-Wave Input |  | 230 | 270 |  | 230 | 270 | $\mu \mathrm{A}$ |
| TEMPERATURE RANGE |  |  |  |  |  |  |  |  |
| Operating, Rated Performance |  |  |  |  |  |  |  |  |
| Commercial ( 0 to $+70^{\circ} \mathrm{C}$ ) |  | AD736JAD736A |  |  | AD736K |  |  |  |
| Industrial ( $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ) |  |  |  |  | AD736B |  |  |  |

NOTES
${ }^{1}$ Accuracy is specified with the AD736 connected as shown in Figure 16 with capacitor $\mathrm{C}_{\mathrm{C}}$.
${ }^{2}$ Nonlinearity is defined as the maximum deviation (in percent error) from a straight line connecting
the readings at 0 and 200 mV rms. Output offset voltage is adjusted to zero.
${ }^{3}$ Error vs. Crest Factor is specified as additional error for a 200 mV rms signal. C.F. $=\mathrm{V}_{\text {PEAK }} / \mathrm{V}$ rms.
${ }^{4} \mathrm{DC}$ offset does not limit ac resolution.
Specifications are subject to change without notice.
Specifications shown in boldface are tested on all production units at final electrical test.
Results from those tests are used to calculate outgoing quality levels.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

| Supply Voltage | 16.5 V | Lead Temperature Range (Soldering 60sec) . . . . . . $+300^{\circ} \mathrm{C}$ |
| :---: | :---: | :---: |
| Internal Power Dissipation ${ }^{2}$ | 200 mW | ESD Rating . . . . . . . . . . . . . . . . . . . . . . . 500 V |
| Input Voltage | $\pm \mathrm{V}_{\mathrm{S}}$ | NOTES |
| Output Short-Circuit Duration | Indefinite | 'Stresses above those listed under "Absolute Maximum Ratings" may cause per- |
| Differential Input Voltage | $+\mathrm{V}_{\mathrm{S}}$ and $-\mathrm{V}_{\mathrm{S}}$ | manent damage to the device. This is a stress rating only and functional opera- |
| Storage Temperature Range (Q) | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ | tion of the device at these or any other conditions above those indicated in the |
| Storage Temperature Range (N, R) | $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | operational section of this specification is not implied. Exposure to absolute |
| Operating Temperature Range |  | maximum rating conditions for extended periods may affect device reliability. ${ }^{2} 8$-Pin Plastic Package: $\theta_{\mathrm{JA}}=165^{\circ} \mathrm{C} / \mathrm{W}$ |
| AD736J/K | 0 to $+70^{\circ} \mathrm{C}$ | 8 -Pin Cerdip Package: $\theta_{\text {JA }}=110^{\circ} \mathrm{C} / \mathrm{W}$ |
| AD736A/B | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Small Outline Package: $\theta_{\mathrm{JA}}=155^{\circ} \mathrm{C} / \mathrm{W}$ |

ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD736JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Plastic Mini-DIP | $\mathrm{N}-8$ |
| AD736KN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Plastic Mini-DIP | $\mathrm{N}-8$ |
| AD736JR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Plastic SOIC | R-8 |
| AD736KR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Plastic SOIC | R-8 |
| AD736AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Cerdip | $\mathrm{Q}-8$ |
| AD736BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Cerdip | Q-8 |
| AD736JR-Reel | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Plastic SOIC | $\mathrm{R}-8$ |
| AD736KR-Reel | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Plastic SOIC | R-8 |

[^248]Lead Temperature Range (Soldering 60sec) ..... $300^{\circ} \mathrm{C}$ESD Rating500 V
${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause per-ion of dheon of the device at these or any other conditions above those indicated in theoperational section of this specification is not implied. Exposure to absolutemaximum rating conditions for extended periods may affect device reliability
${ }^{2} 8$-Pin Plastic Package: $\theta_{\mathrm{JA}}=165^{\circ} \mathrm{C} / \mathrm{W}$
8-Pin Small Outline Package: $\theta_{\mathrm{JA}}=155^{\circ} \mathrm{C} / \mathrm{W}$

Low Cost, Low Power, True RMS-to-DC Converter

## FEATURES <br> COMPUTES

True RMS Value
Average Rectified Value
Absolute Value

PROVIDES<br>200mV Full-Scale Input Range

(Larger Inputs with Input Attenuator)
Direct Interfacing with 3 1/2 Digit CMOS A/D Converters
Power Down Feature Which Reduces Supply Current
High Input Impedance: $10^{12} \Omega$
Low Input Bias Current: 25 pA max
High Accuracy: $\pm 0.2 \mathrm{mV} \pm 0.3 \%$ of Reading RMS Conversion with Signal Crest Factors Up to 5
Wide Power Supply Range: +2.8 V, -3.2 V to $\pm 16.5 \mathrm{~V}$
Low Power: $160 \mu \mathrm{~A}$ max Supply Current
No External Trims Needed for Specified Accuracy
AD736 - A General Purpose, Buffered Voltage Output Version Also Available

## PRODUCT DESCRIPTION

The AD737 is a low power, precision, monolithic true rms-to-dc converter. It is laser trimmed to provide a maximum error of $\pm 0.2 \mathrm{mV} \pm 0.3 \%$ of reading with sine wave inputs. Furthermore, it maintains high accuracy while measuring a wide range of input waveforms, including variable duty cycle pulses and triac (phase) controlled sine waves. The low cost and small physical size of this converter make it suitable for upgrading the performance of non-rms "precision rectifiers" in many applications. Compared to these circuits, the AD737 offers higher accuracy at equal or lower cost.
The AD737 can compute the rms value of both ac and dc input voltages. It can also be operated ac coupled by adding one external capacitor. In this mode, the AD737 can resolve input signal levels of $100 \mu \mathrm{~V}$ rms or less, despite variations in temperature or supply voltage. High accuracy is also maintained for input waveforms with crest factors of 1 to 3 . In addition, crest factors as high as 5 can be measured (while introducing only $2.5 \%$ additional error) at the 200 mV full-scale input level.
The AD737 has no output buffer amplifier, thereby significantly reducing dc offset errors occurring at the output. This allows the device to be highly compatible with high input impedance A/D converters.

Requiring only $160 \mu \mathrm{~A}$ of power supply current, the AD 737 is optimized for use in portable multimeters and other battery

FUNCTIONAL BLOCK DIAGRAM

powered applications. This converter also provides a "power down" feature which reduces the power supply standby current to less than $30 \mu \mathrm{~A}$.
The AD737 allows the choice of two signal input terminals: a high impedance ( $10^{12} \Omega$ ) FET input which will directly interface with high Z input attenuators and a low impedance ( $8 \mathrm{k} \Omega$ ) input which allows the measurement of 300 mV input levels while operating from the minimum power supply voltage of +2.8 V , -3.2 V . The two inputs may be used either singly or differentially.
The AD737 achieves a $1 \%$ of reading error bandwidth exceeding 10 kHz for input amplitudes from 20 mV rms to 200 mV rms while consuming only 0.72 mW .
The AD737 is available in four performance grades. The AD737J and AD737K grades are rated over the commercial temperature range of 0 to $+70^{\circ} \mathrm{C}$. The AD737A and AD737B grades are rated over the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.

The AD737 is available in three low cost, 8-pin packages: plastic mini-DIP, plastic SO and hermetic cerdip.

## PRODUCT HIGHLIGHTS

1. The AD737 is capable of computing the average rectified value, absolute value or true rms value of various input signals.
2. Only one external component, an averaging capacitor, is required for the AD737 to perform true rms measurement.
3. The low power consumption of 0.72 mW makes the AD 737 suitable for many battery powered applications.

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| Model | Conditions | Min | AD737J/A <br> Typ | Max | Min | AD737K/B <br> Typ | Max |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |

NOTES
${ }^{1}$ Accuracy is specified with the AD737 connected as shown in Figure 16 with capacitor $\mathrm{C}_{\mathrm{C}}$.
${ }^{2}$ Nonlinearity is defined as the maximum deviation (in percent error) from a straight line connecting the readings at 0 and 200 mV rms .
${ }^{3}$ Error vs. Crest Factor is specified as additional error for a 200 mV rms signal. C.F. $=\mathrm{V}_{\text {PEAK }} / \mathrm{V} \mathrm{rms}$.
${ }^{4}$ DC offset does not limit ac resolution.
Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$



ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD737JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Plastic Mini-DIP | $\mathrm{N}-8$ |
| AD737KN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Plastic Mini-DIP | N-8 |
| AD737JR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | SOIC | R-8 |
| AD737KR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | SOIC | R-8 |
| AD737AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Cerdip | Q-8 |
| AD737BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Cerdip | Q-8 |
| AD737JR-Reel | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | SOIC | R-8 |
| AD737KR-Reel | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | SOIC | R-8 |

*For outline information see Package Information section.

## PIN CONFIGURATIONS 8-Pin Mini-DIP (N-8), 8-Pin SOIC (R-8) 8-Pin Cerdip (Q-8)



## Sensors and Signal Conditioners

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## Selection Tree - Sensors and Signal Conditioners



AD693 (4-20 mA Sensor Transmitter)
AD694 (4-20 Transmitter)

Selection Guides-Sensors and Signal Conditioners

## Temperature Sensors

| Model | $\mathrm{I}_{\text {OUT }}$ $\mu \mathbf{A} / \mathbf{K}$ | $V_{\text {our }}$ mV/K | Cal Error ${ }^{\circ} \mathrm{C}$ max | Nonlin ${ }^{\circ} \mathrm{C}$ max | Package <br> Options ${ }^{1}$ | Temp <br> Ranges ${ }^{2}$ | Page ${ }^{3}$ | Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| AC2626 | 1 | - | 0.5-5 | 0.3-1.5 Steel Sheath | 3/16" Stainless | C, M | SL 10-5 | General Purpose Temperature Probe $4^{\prime \prime}$ and $6^{\prime \prime}$ Length |
| AD590 | 1 | - | 0.5-5 | 0.3-1.5 | F, H | $\mathbf{M}+/_{\text {DS }}$ | 19-5 | Wide Temperature Range, Accurate |
| AD592 | 1 | - | 0.5-2.5 | 0.15-0.35 | N | I+ | 19-9 | Low Cost, Accurate |
| TMP01 | - | 5 | 1.5-3 | 0.5-2.0 | H, N, R | I, M + | 19-57 | Complete Programmable Temperature Controller |
| TMP03 | - | - | 1.2-2.4 | 1.0 | H, R, T | M+ | 19-72 | 3 Pins, Direct Serial Digital Output |
| AD22100 | - | 22.5 | 2.0 | 1-2 | R, T | M + | 19-31 | 3 Pins, Output Proportional to V+ |

Sensor Interfaces


FEATURES
Linear Current Output: $1 \mu \mathrm{~A} / \mathrm{K}$
Wide Range: $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Probe Compatible Ceramic Sensor Package
Two-Terminal Device: Voltage In/Current Out
Laser Trimmed to $\pm 0.5^{\circ} \mathrm{C}$ Calibration Accuracy (AD590M)
Excellent Linearity: $\pm 0.3^{\circ} \mathrm{C}$ Over Full Range (AD590M)
Wide Power Supply Range: +4V to +30V
Sensor Isolation from Case
Low Cost

PIN DESIGNATIONS


BOTTOM VIEW

## PRODUCT DESCRIPTION

The AD590 is a two-terminal integrated circuit temperature transducer which produces an output current proportional to absolute temperature. For supply voltages between +4 V and +30 V the device acts as a high impedance, constant current regulator passing $1 \mu \mathrm{~A} / \mathrm{K}$. Laser trimming of the chip's thin film resistors is used to calibrate the device to $298.2 \mu \mathrm{~A}$ output at $298.2 \mathrm{~K}\left(+25^{\circ} \mathrm{C}\right)$.

The AD590 should be used in any temperature sensing application below $+150^{\circ} \mathrm{C}$ in which conventional electrical temperature sensors are currently employed. The inherent low cost of a monolithic integrated circuit combined with the elimination of support circuitry makes the AD590 an attractive alternative for many temperature measurement situations. Linearization circuitry, precision voltage amplifiers, resistance measuring circuitry and cold junction compensation are not needed in applying the AD590.
In addition to temperature measurement, applications include temperature compensation or correction of discrete components, biasing proportional to absolute temperature, flow rate measurement, level detection of fluids and anemometry. The AD590 is available in chip form making it suitable for hybrid circuits and fast temperature measurements in protected environments.
The AD590 is particularly useful in remote sensing applications. The device is insensitive to voltage drops over long lines due to its high impedance current output. Any well-insulated twisted pair is sufficient for operation hundreds of feet from the receiving circuitry. The output characteristics also make the AD590 easy to multiplex: the current can be switched by a CMOS multiplexer or the supply voltage can be switched by a logic gate output.

[^250]
## PRODUCT HIGHLIGHTS

1. The AD590 is a calibrated two terminal temperature sensor requiring only a dc voltage supply ( +4 V to +30 V ). Costly transmitters, filters, lead wire compensation and linearization circuits are all unnecessary in applying the device.
2. State-of-the-art laser trimming at the wafer level in conjunction with extensive final testing insures that AD590 units are easily interchangeable.
3. Superior interference rejection results from the output being a current rather than a voltage. In addition, power requirements are low ( 1.5 mW 's @ 5 V @ $+25^{\circ} \mathrm{C}$ ). These features make the AD590 easy to apply as a remote sensor.
4. The high output impedance ( $>10 \mathrm{M} \Omega$ ) provides excellent rejection of supply voltage drift and ripple. For instance, changing the power supply from 5 V to 10 V results in only a $1 \mu \mathrm{~A}$ maximum current change, or $1^{\circ} \mathrm{C}$ equivalent error.
5. The AD590 is electrically durable: it will withstand a forward voltage up to 44 V and a reverse voltage of 20 V . Hence, supply irregularities or pin reversal will not damage the device.

## AD590 <br> SPECIFICATIONS <br> (@ $+25^{\circ} \mathrm{C}$ and $\mathrm{V}_{\mathrm{s}}=+5 \mathrm{~V}$ unless otherwise noted)

| Model | AD590J |  |  | AD590K |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max |  |
| ABSOLUTE MAXIMUM RATINGS |  |  |  |  |  |  |  |
| Forward Voltage ( $\mathrm{E}+$ to $\mathrm{E}-$ ) |  |  | +44 |  |  | +44 | Volts |
| Reverse Voltage ( $\mathrm{E}+$ to E -) |  |  | -20 |  |  | -20 | Volts |
| Breakdown Voltage (Case to $\mathrm{E}+$ or E -) |  |  | $\pm 200$ |  |  | $\pm 200$ | Volts |
| Rated Performance Temperature Range ${ }^{1}$ | -55 |  | +150 | -55 |  | +150 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature Range ${ }^{1}$ | -65 |  | +155 | -65 |  | +155 | ${ }^{\circ} \mathrm{C}$ |
| Lead Temperature (Soldering, 10 sec ) |  |  | +300 |  |  | +300 | ${ }^{\circ} \mathrm{C}$ |
| POWER SUPPLY |  |  |  |  |  |  |  |
| Operating Voltage Range | +4 |  | +30 | +4 |  | +30 | Volts |
| OUTPUT |  |  |  |  |  |  |  |
| Nominal Current Output @ + $25^{\circ} \mathrm{C}$ ( 298.2 K ) |  | 298.2 |  |  | 298.2 |  | $\mu \mathrm{A}$ |
| Nominal Temperature Coefficient |  | 1 |  |  | 1 |  | $\mu \mathrm{A} / \mathrm{K}$ |
| Calibration Error @ + $25^{\circ} \mathrm{C}$ |  |  | $\pm 5.0$ |  |  | $\pm 2.5$ | ${ }^{\circ} \mathrm{C}$ |
| Absolute Error (over rated performance temperature range) |  |  |  |  |  |  |  |
| Without External Calibration Adjustment |  |  | $\pm 10$ |  |  | $\pm 5.5$ | ${ }^{\circ} \mathrm{C}$ |
| With $+25^{\circ} \mathrm{C}$ Calibration Error Set to Zero |  |  | $\pm 3.0$ |  |  | $\pm 2.0$ | ${ }^{\circ} \mathrm{C}$ |
| Nonlinearity |  |  | $\pm 1.5$ |  |  | $\pm 0.8$ | ${ }^{\circ} \mathrm{C}$ |
| Repeatability ${ }^{2}$ |  |  | $\pm 0.1$ |  |  | $\pm 0.1$ | ${ }^{\circ} \mathrm{C}$ |
| Long Term Drift ${ }^{3}$ |  |  | $\pm 0.1$ |  |  | $\pm 0.1$ | ${ }^{\circ} \mathrm{C}$ |
| Current Noise |  | 40 |  |  | 40 |  | $\mathrm{pA} / \sqrt{\mathbf{H z}}$ |
| Power Supply Rejection |  |  |  |  |  |  |  |
| $+4 \mathrm{~V} \leq \mathrm{V}_{\mathrm{S}} \leq+5 \mathrm{~V}$ |  | 0.5 |  |  | 0.5 |  | $\mu \mathrm{A} / \mathrm{V}$ |
| $+5 \mathrm{~V} \leq \mathrm{V}_{\mathbf{S}} \leq+15 \mathrm{~V}$ |  | 0.2 |  |  | 0.2 |  | $\mu \mathrm{A} / \mathrm{V}$ |
| $+15 \mathrm{~V} \leq \mathrm{V}_{\mathrm{S}} \leq+30 \mathrm{~V}$ |  | 0.1 |  |  | 0.1 |  | $\mu \mathrm{A} / \mathrm{V}$ |
| Case Isolation to Either Lead |  | $10^{10}$ |  |  | $10^{10}$ |  | $\Omega$ |
| Effective Shunt Capacitance |  | 100 |  |  | 100 |  | pF |
| Electrical Turn-On Time |  | 20 |  |  | 20 |  | $\mu \mathrm{s}$ |
| Reverse Bias Leakage Current ${ }^{4}$ $($ Reverse Voltage $=10 \mathrm{~V}$ ) |  | 10 |  |  | 10 |  | pA |
| PACKAGE OPTIONS ${ }^{5}$ |  |  |  |  |  |  |  |
| TO-52(H-03A) |  | AD590 |  |  | AD590 |  |  |
| Flat Pack (F-2A) |  | AD590 |  |  | AD590 |  |  |

## NOTES

${ }^{1}$ The AD590 has been used at $-100^{\circ} \mathrm{C}$ and $+200^{\circ} \mathrm{C}$ for short periods of measurement with no physical damage to the device. However, the absolute errors specified apply to only the rated performance temperature range.
${ }^{2}$ Maximum deviation between $+25^{\circ} \mathrm{C}$ readings after temperature cycling between $-55^{\circ} \mathrm{C}$ and $+150^{\circ} \mathrm{C}$; guaranteed not tested.
${ }^{3}$ Conditions: constant +5 V , constant $+125^{\circ} \mathrm{C}$; guaranteed, not tested.
${ }^{4}$ Leakage current doubles every $10^{\circ} \mathrm{C}$.
${ }^{5}$ For outline information see Package Information section.
Specifications subject to change without notice.
Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.

| Model | AD590L |  |  | AD590M |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max |  |
| ABSOLUTE MAXIMUM RATINGS |  |  |  |  |  |  |  |
| Forward Voltage ( $\mathrm{E}+$ to $\mathrm{E}-$ ) |  |  | +44 |  |  | +44 | Volts |
| Reverse Voltage ( $\mathrm{E}+$ to $\mathrm{E}-$ ) |  |  | -20 |  |  | -20 | Volts |
| Breakdown Voltage (Case to $\mathrm{E}+$ or $\mathrm{E}-$ ) |  |  | $\pm 200$ |  |  | $\pm 200$ | Volts |
| Rated Performance Temperature Range ${ }^{1}$ | -55 |  | +150 | -55 |  | +150 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature Range ${ }^{1}$ | -65 |  | +155 | -65 |  | +155 | ${ }^{\circ} \mathrm{C}$ |
| Lead Temperature (Soldering, 10 sec ) |  |  | $+300$ |  |  | +300 | ${ }^{\circ} \mathrm{C}$ |
| POWER SUPPLY |  |  |  |  |  |  |  |
| Operating Voltage Range | +4 |  | +30 | +4 |  | +30 | Volts |
| OUTPUT |  |  |  |  |  |  |  |
| Nominal Current Output @ + $25^{\circ} \mathrm{C}(298.2 \mathrm{~K}$ ) |  | 298.2 |  |  | 298.2 |  | $\mu \mathrm{A}$ |
| Nominal Temperature Coefficient |  | 1 |  |  | 1 |  | $\mu \mathrm{A} / \mathrm{K}$ |
| Calibration Error@+25 ${ }^{\circ} \mathrm{C}$ |  |  | $\pm 1.0$ |  |  | $\pm 0.5$ | ${ }^{\circ} \mathrm{C}$ |
| Absolute Error (over rated performance temperature range) |  |  |  |  |  |  |  |
| Without External Calibration Adjustment |  |  | $\pm 3.0$ |  |  | $\pm 1.7$ | ${ }^{\circ} \mathrm{C}$ |
| With $+25^{\circ} \mathrm{C}$ Calibration Error Set to Zero |  |  | $\pm 1.6$ |  |  | $\pm 1.0$ | ${ }^{\circ} \mathrm{C}$ |
| Nonlinearity |  |  | $\pm 0.4$ |  |  | $\pm 0.3$ | ${ }^{\circ} \mathrm{C}$ |
| Repeatability ${ }^{2}$ |  |  | $\pm 0.1$ |  |  | $\pm 0.1$ | ${ }^{\circ} \mathrm{C}$ |
| Long Term Drift ${ }^{3}$ |  |  | $\pm 0.1$ |  |  | $\pm 0.1$ | ${ }^{\circ} \mathrm{C}$ |
| Current Noise |  | 40 |  |  | 40 |  | $\mathrm{pA} \sqrt{\mathrm{Hz}}$ |
| Power Supply Rejection |  |  |  |  |  |  |  |
| $+4 \mathrm{~V} \leq \mathrm{V}_{\mathrm{S}} \leq+5 \mathrm{~V}$ |  | 0.5 |  |  | 0.5 |  | $\mu \mathrm{A} / \mathrm{V}$ |
| $+5 \mathrm{~V} \leq \mathrm{V}_{S} \leq+15 \mathrm{~V}$ |  | 0.2 |  |  | 0.2 |  | $\mu \mathrm{A} / \mathrm{V}$ |
| $+15 \mathrm{~V} \leq \mathrm{V}_{\mathrm{s}} \leq+30 \mathrm{~V}$ |  | 0.1 |  |  | 0.1 |  | $\mu \mathrm{A} / \mathrm{V}$ |
| Case Isolation to Either Lead |  | $10^{10}$ |  |  | $10^{10}$ |  | $\Omega$ |
| Effective Shunt Capacitance |  | 100 |  |  | 100 |  | pF |
| Electrical Turn-On Time |  | 20 |  |  | 20 |  | $\mu \mathrm{s}$ |
| Reverse Bias Leakage Current ${ }^{4}$ <br> $($ Reverse Voltage $=10 \mathrm{~V}$ ) |  | 10 |  |  | 10 |  | pA |
| PACKAGE OPTION ${ }^{5}$ |  |  |  |  |  |  |  |
| TO-52(H-03A) |  | AD590L |  |  | AD590 |  |  |
| Flat Pack (F-2A) |  | AD590L |  |  | AD590 |  |  |



TEMPERATURE SCALE CONVERSION EQUATIONS

$$
\begin{array}{ll}
{ }^{\circ} \mathrm{C}=\frac{5}{9}\left({ }^{\circ} \mathrm{F}-32\right) & \mathrm{K}={ }^{\circ} \mathrm{C}+273.15 \\
{ }^{\circ} \mathrm{F}=\frac{9}{5}{ }^{\circ} \mathrm{C}+32 & { }^{\circ} \mathrm{R}={ }^{\circ} \mathrm{F}+459.7
\end{array}
$$

The 590 H has $60 \mu$ inches of gold plating on its Kovar leads and Kovar header. A resistance welder is used to seal the nickel cap to the header. The AD590 chip is eutectically mounted to the header and ultrasonically bonded to with 1 MIL aluminum wire. Kovar composition: $53 \%$ iron nominal; $29 \% \pm 1 \%$ nickel; $17 \% \pm 1 \%$ cobalt; $0.65 \%$ manganese max; $0.20 \%$ silicon max; $0.10 \%$ aluminum max; $0.10 \%$ magnesium max; $0.10 \%$ zirconium max; $0.10 \%$ titanium max; $0.06 \%$ carbon max.

The 590 F is a ceramic package with gold plating on its Kovar leads, Kovar lid, and chip cavity. Solder of 80/20 Au/Sn composition is used for the 1.5 mil thick solder ring under the lid. The chip cavity has a nickel underlay between the metalization and the gold plating. The AD590 chip is eutectically mounted in the chip cavity at $410^{\circ} \mathrm{C}$ and ultrasonically bonded to with 1 mil aluminum wire. Note that the chip is in direct contact with the ceramic base, not the metal lid. When using the AD590 in die form, the chip substrate must be kept electrically isolated, (floating), for correct circuit operation.

## METALIZATION DIAGRAM



THE AD590 IS AVAILABLE IN LASER-TRIMMED CHIP FORM; CONSULT THE CHIP CATALOG FOR DETAILS.

## CIRCUIT DESCRIPTION ${ }^{1}$

The AD590 uses a fundamental property of the silicon transistors from which it is made to realize its temperature proportional characteristic: if two identical transistors are operated at a constant ratio of collector current densities, $r$, then the difference in their base-emitter voltages will be ( $\mathrm{kT} / \mathrm{q}$ )(In r). Since both k, Boltzman's constant and q, the charge of an electron, are constant, the resulting voltage is directly porportional to absolute temperature (PTAT).

In the AD590, this PTAT voltage is converted to a PTAT current by low temperature coefficient thin film resistors. The total current of the device is then forced to be a multiple of this PTAT current. Referring to Figure 1, the schematic diagram of the AD590, Q8 and Q11 are the transistors that produce the PTAT voltage. R5 and R6 convert the voltage to current. Q10, whose collector current tracks the collector currents in Q9 and Q11, supplies all the bias and substrate leakage current for the rest of the circuit, forcing the total current to be PTAT. R5 and R6 are laser trimmed on the wafer to calibrate the device at $+25^{\circ} \mathrm{C}$.

Figure 2 shows the typical $V-I$ characteristic of the circuit at $+25^{\circ} \mathrm{C}$ and the temperature extremes.


Figure 1. Schematic Diagram


Figure 2. V-I Plot

[^251]Low Cost, Precision IC Temperature Transducer

## FEATURES

High Precalibrated Accuracy: $0.5^{\circ} \mathrm{C}$ max @ $25^{\circ} \mathrm{C}$
Excellent Linearity: $0.15^{\circ} \mathrm{C}$ max ( 0 to $+70^{\circ} \mathrm{C}$ )
Wide Operating Temperature Range: $-25^{\circ} \mathrm{C}$ to $+105^{\circ} \mathrm{C}$
Single Supply Operation: +4V to +30V
Excellent Repeatability and Stability
High Level Output: 1 $\mu \mathrm{A} / \mathrm{K}$
Two Terminal Monolithic IC: Temperature In/ Current Out
Minimal Self-Heating Errors

## PRODUCT DESCRIPTION

The AD592 is a two terminal monolithic integrated circuit temperature transducer that provides an output current proportional to absolute temperature. For a wide range of supply voltages the transducer acts as a high impedance temperature dependent current source of $1 \mu \mathrm{~A} / \mathrm{K}$. Improved design and laser wafer trimming of the IC's thin film resistors allows the AD592 to achieve absolute accuracy levels and nonlinearity errors previously unattainable at a comparable price.
The AD592 can be employed in applications between $-25^{\circ} \mathrm{C}$ and $+105^{\circ} \mathrm{C}$ where conventional temperature sensors (i.e., thermistor, RTD, thermocouple, diode) are currently being used. The inherent low cost of a monolithic integrated circuit in a plastic package, combined with a low total parts count in any given application, make the AD592 the most cost effective temperature transducer currently available. Expensive linearization circuitry, precision voltage references, bridge components, resistance measuring circuitry and cold junction compensation are not required with the AD592.
Typical application areas include; appliance temperature sensing, automotive temperature measurement and control, HVAC (heating/ventilating/air conditioning) system monitoring, industrial temperature control, thermocouple cold junction compensation, board-level electronics temperature diagnostics, temperature readout options in instrumentation, and temperature correction circuitry for precision electronics. Particularily useful in remote sensing applications, the AD592 is immune to voltage drops and voltage noise over long lines due to its high impedance current output. AD592s can easily be multiplexed; the signal current can be switched by a CMOS multiplexer or the supply voltage can be enabled with a tri-state logic gate.

## CONNECTION DIAGRAM


*PIN 2 CAN BE EITHER ATTACHED OR UNCONNECTED BOTTOM VIEW

The AD592 is available in three performance grades; the AD592AN, AD592BN and AD592CN. All devices are packaged in a plastic TO-92 case rated from $-45^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. Performance is specified from $-25^{\circ} \mathrm{C}$ to $+105^{\circ} \mathrm{C}$. AD592 chips are also available, contact the factory for details.

## PRODUCT HIGHLIGHTS

1. With a single supply ( 4 V to 30 V ) the AD592 offers $0.5^{\circ} \mathrm{C}$ temperature measurement accuracy.
2. A wide operating temperature range $\left(-25^{\circ} \mathrm{C}\right.$ to $\left.+105^{\circ} \mathrm{C}\right)$ and highly linear output make the AD592 an ideal substitute for older, more limited sensor technologies (i.e., thermistors, RTDs, diodes, thermocouples).
3. The AD592 is electrically rugged; supply irregularities and variations or reverse voltages up to 20 V will not damage the device.
4. Because the AD592 is a temperature dependent current source, it is immune to voltage noise pickup and IR drops in the signal leads when used remotely.
5. The high output impedance of the AD592 provides greater than $0.5^{\circ} \mathrm{C} / \mathrm{V}$ rejection of supply voltage drift and ripple.
6. Laser wafer trimming and temperature testing insures that AD592 units are easily interchangeable.
7. Initial system accuracy will not degrade significantly over time. The AD592 has proven long term performance and repeatability advantages inherent in integrated circuit design and construction.

[^252] complete data sheet, call our fax retrieval system at 1-800-446-6212.

## AD592-SPECIFICATIONS <br> (typical @ $+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{S}}=+5 \mathrm{~V}$ unless otherwise noted)

| Model | Min | $\begin{aligned} & \text { ADS9 } \\ & \text { Typ } \end{aligned}$ | Max | Min | $\begin{aligned} & \text { AD59: } \\ & \text { Typ } \end{aligned}$ | Max | Min | $\begin{aligned} & \text { AD59 } \\ & \text { Typ } \end{aligned}$ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ACCURACY |  |  |  |  |  |  |  |  |  |  |
| Calibration Error @ $25^{\circ} \mathrm{C}{ }^{1}$ |  | 1.5 | 2.5 |  | 0.7 | 1.0 |  | 0.3 | 0.5 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{A}}=0$ to $+70^{\circ} \mathrm{C}$ |  |  |  |  |  |  |  |  |  |  |
| Error over Temperature |  | 1.8 | 3.0 |  | 0.8 | 1.5 |  | 0.4 | 0.8 | ${ }^{\circ} \mathrm{C}$ |
| Nonlinearity ${ }^{2}$ |  | 0.15 | 0.35 |  | 0.1 | 0.25 |  | 0.05 | 0.15 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{A}}=-25$ to $+105^{\circ} \mathrm{C}$ |  |  |  |  |  |  |  |  |  |  |
| Error over Temperature ${ }^{3}$ |  | 2.0 | 3.5 |  | 0.9 | 2.0 |  | 0.5 | 1.0 | ${ }^{\circ} \mathrm{C}$ |
| Nonlinearity ${ }^{2}$ |  | 0.25 | 0.5 |  | 0.2 | 0.4 |  | 0.1 | 0.35 | ${ }^{\circ} \mathrm{C}$ |
| OUTPUT CHARACTERISTICS |  |  |  |  |  |  |  |  |  |  |
| Nominal Current Output |  |  |  |  |  |  |  |  |  |  |
| @ $25^{\circ} \mathrm{C}$ (298.2K) |  | 298.2 |  |  | 298.2 |  |  | 298.2 |  | $\mu \mathbf{A}$ |
| Temperature Coefficient |  | 1 |  |  | 1 |  |  | 1 |  | $\mu \mathbf{A}^{\circ} \mathbf{C}$ |
| Repeatability ${ }^{4}$ |  |  | 0.1 |  |  | 0.1 |  |  | 0.1 | ${ }^{\circ} \mathrm{C}$ |
| Long Term Stability ${ }^{5}$ |  |  | 0.1 |  |  | 0.1 |  |  | 0.1 | ${ }^{\circ} \mathrm{C}$ /month |
| ABSOLUTE MAXIMUM RATINGS |  |  |  |  |  |  |  |  |  |  |
| Operating Temperature | -25 |  | + 105 | -25 |  | + 105 | -25 |  | $+105$ | ${ }^{\circ} \mathrm{C}$ |
| Package Temperature ${ }^{6}$ | -45 |  | +125 | -45 |  | + 125 | -45 |  | $+125$ | ${ }^{\circ} \mathrm{C}$ |
| Forward Voltage ( + to - ) |  |  | 44 |  |  | 44 |  |  | 44 | V |
| Reverse Voltage ( - to + ) |  |  | 20 |  |  | 20 |  |  | 20 | V |
| Lead Temperature |  |  |  |  |  |  |  |  |  |  |
| (Soldering 10 sec ) |  |  | 300 |  |  | 300 |  |  | 300 | ${ }^{\circ} \mathrm{C}$ |
|  |  |  |  |  |  |  |  |  |  |  |
| Operating Voltage Range | 4 |  | 30 | 4 |  | 30 | 4 | - | 30 | V |
| Power Supply Rejection |  |  |  |  |  |  |  |  |  |  |
| $+4 \mathrm{~V}<\mathrm{V}_{\mathrm{S}}<+5 \mathrm{~V}$ |  |  | 0.5 |  |  | 0.5 |  |  | 0.5 | ${ }^{\circ} \mathrm{C} / \mathrm{V}$ |
| $+5 \mathrm{~V}<\mathrm{V}_{\mathrm{S}}<+15 \mathrm{~V}$ |  |  | 0.2 |  |  | 0.2 |  |  | 0.2 | ${ }^{\circ} \mathrm{C} / \mathrm{V}$ |
| $+15 \mathrm{~V}<\mathrm{V}_{\mathbf{S}}<+30 \mathrm{~V}$ |  |  | 0.1 |  |  | 0.1 |  |  | 0.1 | ${ }^{\circ} \mathrm{C} / \mathrm{V}$ |

NOTES
${ }^{1}$ An external calibration trim can be used to zero the error @ $25^{\circ} \mathrm{C}$.
${ }^{2}$ Defined as the maximum deviation from a mathematically best fit line.
${ }^{3}$ Parameter tested on all production units at $+105^{\circ} \mathrm{C}$ only. C grade at $-25^{\circ} \mathrm{Calso}$.
${ }^{4}$ Maximum deviation between $+25^{\circ} \mathrm{C}$ readings after a temperature cycle between $-45^{\circ} \mathrm{C}$ and $+125^{\circ} \mathrm{C}$. Errors of this type are noncummulative.
${ }^{s}$ Operation @ $125^{\circ} \mathrm{C}$, error over time is noncummulative.
${ }^{6}$ Although performance is not specified beyond the operating temperature range, temperature excursions within the package temperature range will not damage the device. Specifications subject to change without notice.

Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All $\min$ and $\max$ specifications are guaranteed, although only those shown in boldface are tested on all production units.

METALIZATION DIAGRAM


THE AD592 IS AVAILABLE IN LASER-TRIMMED CHIP FORM.


TEMPERATURE SCALE CONVERSION EQUATIONS

$$
\begin{array}{ll}
{ }^{\circ} \mathrm{C}=\frac{5}{9}\left({ }^{\circ} \mathrm{F}-32\right) & \mathrm{K}={ }^{\circ} \mathrm{C}+273.15 \\
{ }^{\circ} \mathrm{F}=\frac{9}{5}{ }^{\circ} \mathrm{C}+32 & { }^{\circ} \mathrm{R}={ }^{\circ} \mathrm{F}+459.7
\end{array}
$$

ORDERING GUIDE

|  | Max Cal <br> Error @ $25^{\circ} \mathrm{C}$ | Max Error <br> $-\mathbf{2 5} 5^{\circ} \mathrm{C}$ to $+105^{\circ} \mathrm{C}$ | Max Nonlinearity <br> $-25^{\circ} \mathrm{C}$ to $+105^{\circ} \mathrm{C}$ | Package <br> Option |
| :--- | :--- | :--- | :--- | :--- |
| AD592CN | $0.5^{\circ} \mathrm{C}$ | $1.0^{\circ} \mathrm{C}$ | $0.35^{\circ} \mathrm{C}$ | TO-92 |
| AD592BN | $1.0^{\circ} \mathrm{C}$ | $2.0^{\circ} \mathrm{C}$ | $0.4^{\circ} \mathrm{C}$ | TO-92 |
| AD592AN | $2.5^{\circ} \mathrm{C}$ | $3.5^{\circ} \mathrm{C}$ | $0.5^{\circ} \mathrm{C}$ | TO-92 |

[^253]
## Typical @ $\mathbf{V}_{\mathbf{s}}=+\mathbf{5 V}$



AD592CN Accuracy Over Temperature


AD592AN Accuracy Over Temperature


AD592BN Accuracy Over Temperature


Long-Term Stability @ $85^{\circ} \mathrm{C}$ and $85 \%$ Relative Humidity


Long-Term Stability @ $125^{\circ} \mathrm{C}$

## FEATURES

Pretrimmed for Type J (AD594) or Type K (AD595) Thermocouples Can Be Used with Type T Thermocouple Inputs
Low Impedance Voltage Output: $10 \mathrm{mV} /{ }^{\circ} \mathrm{C}$
Built-in Ice Point Compensation
Wide Power Supply Range: $\mathbf{+ 5 V}$ to $\pm 15 \mathrm{~V}$
Low Power: <1mW typical
Thermocouple Failure Alarm
Laser Wafer Trimmed to $1^{\circ} \mathrm{C}$ Calibration Accuracy
Set-Point Mode Operation
Self-Contained Celsius Thermometer Operation
High Impedance Differential Input
Side-Brazed DIP or Low Cost Cerdip

FUNCTIONAL BLOCK DIAGRAM


## PRODUCT DESCRIPTION

The AD594/AD595 is a complete instrumentation amplifier and thermocouple cold junction compensator on a monolithic chip. It combines an ice point reference with a precalibrated amplifier to produce a high level $\left(10 \mathrm{mV} /{ }^{\circ} \mathrm{C}\right)$ output directly from a thermocouple signal. Pin-strapping options allow it to be used as a linear amplifier-compensator or as a switched output-set-point controller using either fixed or remote set-point control. It can be used to amplify its compensation voltage directly, thereby converting it to a stand-alone Celsius transducer with a low-impedance voltage output.
The AD594/AD595 includes a thermocouple failure alarm that indicates if one or both thermocouple leads become open. The alarm output has a flexible format which includes TTL drive capability.
The AD594/AD595 can be powered from a single ended supply (including +5 V ) and by including a negative supply, temperatures below $0^{\circ} \mathrm{C}$ can be measured. To minimize self-heating, an unloaded AD594/AD595 will typically operate with a total supply current of $160 \mu \mathrm{~A}$, but is also capable of delivering in excess of $\pm 5 \mathrm{~mA}$ to a load.
The AD594 is precalibrated by laser wafer trimming to match the characteristic of type $J$ (iron-constantan) thermocouples and the AD595 is laser trimmed for type K (chromel-alumel) inputs. The temperature transducer voltages and gain control resistors are available at the package pins so that the circuit can be recalibrated for other thermocouple types by the addition of two or three resistors. These terminals also allow more precise calibration for both thermocouple and thermometer applications.
*Protected by U.S. Patent No. 4,029,974.

The AD594/AD595 is available in two performance grades. The C and the A versions have calibration accuracies of $\pm 1^{\circ} \mathrm{C}$ and $\pm 3^{\circ} \mathrm{C}$, respectively. Both are designed to be used from 0 to $+50^{\circ} \mathrm{C}$, and are available in 14-pin, hermetically sealed, sidebrazed ceramic DIPs as well as low cost cerdip packages.

## PRODUCT HIGHLIGHTS

1. The AD594/AD595 provides cold junction compensation, amplification, and an output buffer in a single IC package.
2. Compensation, zero, and scale factor are all precalibrated by laser wafer trimming (LWT) of each IC chip.
3. Flexible pin-out provides for operation as a set-point controller or a stand-alone temperature transducer calibrated in degrees Celsius.
4. Operation at remote application sites is facilitated by low quiescent current and a wide supply voltage range of +5 V to dual supplies spanning 30 V .
5. Differential input rejects common-mode noise voltage on the thermocouple leads.

[^254]

## NOTES

 when the measuring junction is at $0^{\circ} \mathrm{C}$. The AD595 will similarly read 2.7 mV at $0^{\circ} \mathrm{C}$.
${ }^{2}$ Defined as the slope of the line connecting the AD594/AD595 errors measured at $0^{\circ} \mathrm{C}$ and $50^{\circ} \mathrm{C}$ ambient temperature.
${ }^{3}$ Pin 8 shorted to Pin 9.
${ }^{4}$ Current Sink Capability in single supply configuration is limited to current drawn to ground through a $50 \mathrm{k} \Omega$ resistor at output voltages below 2.5 V .
${ }^{5}-V_{\mathrm{S}}$ must not exceed -16.5 V .
${ }^{6}$ For outline information see Package Information section.
Specifications subject to change without notice.
Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.

| Thermocouple Temperature ${ }^{\circ} \mathrm{C}$ | Type J <br> Voltage mV | AD594 <br> Output mV | Type K <br> Voltage <br> mV | AD595 <br> Output mV | Thermocouple Temperature ${ }^{\circ} \mathrm{C}$ | Type J Voltage mV | AD594 <br> Output mV | Type K Voltage mV | AD595 <br> Output mV |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| - 200 | $-7.890$ | -1523 | - 5.891 | -1454 | 500 | 27.388 | 5300 | 20.640 | 5107 |
| - 180 | - 7.402 | -1428 | - 5.550 | -1370 | 520 | 28.511 | 5517 | 21.493 | 5318 |
| - 160 | - 6.821 | - 1316 | - 5.141 | -1269 | 540 | 29.642 | 5736 | 22.346 | 5529 |
| - 140 | - 6.159 | -1188 | - 4.669 | -1152 | 560 | 30.782 | 5956 | 23.198 | 5740 |
| - 120 | - 5.426 | -1046 | -4.138 | -1021 | 580 | 31.933 | 6179 | 24.050 | 5950 |
| - 100 | $-4.632$ | - 893 | - 3.553 | - 876 | 600 | 33.096 | 6404 | 24.902 | 6161 |
| - 80 | - 3.785 | - 729 | - 2.920 | - 719 | 620 | 34.273 | 6632 | 25.751 | 6371 |
| - 60 | - 2.892 | - 556 | - 2.243 | - 552 | 640 | 35.464 | 6862 | 26.599 | 6581 |
| - 40 | - 1.960 | - 376 | - 1.527 | - 375 | 660 | 36.671 | 7095 | 27.445 | 6790 |
| - 20 | - . 995 | - 189 | - . 777 | - 189 | 680 | 37.893 | 7332 | 28.288 | 6998 |
| - 10 | - . 501 | - 94 | - .392 | - 94 | 700 | 39.130 | 7571 | 28.128 | 7206 |
| 0 | 0 | 3.1 | 0 | 2.7 | 720 | 40.382 | 7813 | 29.965 | 7413 |
| 10 | . 507 | 101 | . 397 | 101 | 740 | 41.647 | 8058 | 30.799 | 7619 |
| 20 | 1.019 | 200 | . 798 | 200 | 750 | 42.283 | 8181 | 31.214 | 7722 |
| 25 | 1.277 | 250 | 1.000 | 250 | 760 | - | - | 31.629 | 7825 |
| 30 | 1.536 | 300 | 1.203 | 300 | 780 | - | - | 32.455 | 8029 |
| 40 | 2.058 | 401 | 1.611 | 401 | 800 | - | - | 33.277 | 8232 |
| 50 | 2.585 | 503 | 2.022 | 503 | 820 | - | - | 34.095 | 8434 |
| 60 | 3.115 | 606 | 2.436 | 605 | 840 | - | - | 34.909 | 8636 |
| 80 | 4.186 | 813 | 3.266 | 810 | 860 | - | - | 35.718 | 8836 |
| 100 | 5.268 | 1022 | 4.095 | 1015 | 880 | - | - | 36.524 | 9035 |
| 120 | 6.359 | 1233 | 4.919 | 1219 | 900 | - | - | 37.325 | 9233. |
| 140 | 7.457 | 1445 | 5.733 | 1420 | 920 | - | - | 38.122 | 9430 |
| 160 | 8.560 | 1659 | 6.539 | 1620 | 940 | - | - | 38.915 | 9626 |
| 180 | 9.667 | 1873 | 7.338 | 1817 | 960 | - | - | 39.703 | 9821 |
| 200 | 10.777 | 2087 | 8.137 | 2015 | 980 | - | - | 40.488 | 10015 |
| 220 | 11.887 | 2302 | 8.938 | 2213 | 1000 | - | - | 41.269 | 10209 |
| 240 | 12.998 | 2517 | 9.745 | 2413 | 1020 | - | - | 42.045 | 10400 |
| 260 | 14.108 | 2732 | 10.560 | 2614 | 1040 | - | - | 42.817 | 10591 |
| 280 | 15.217 | 2946 | 11.381 | 2817 | 1060 | - | - | 43.585 | 10781 |
| 300 | 16.325 | 3160 | 12.207 | 3022 | 1080 | - | - | 44.349 | 10970 |
| 320 | 17.432 | 3374 | 13.039 | 3327 | 1100 | - | - | 45.108 | 11158 |
| 340 | 18.537 | 3588 | 13.874 | 3434 | 1120 | - | - | 45.863 | 11345 |
| 360 | 19.640 | 3801 | 14.712 | 3641 | 1140 | - | - | 46.612 | 11530 |
| 380 | 20.743 | 4015 | 15.552 | 3849 | 1160 | - | - | 47.356 | 11714 |
| 400 | 21.846 | 4228 | 16.395 | 4057 | 1180 | - | - | 48.095 | 11897 |
| 420 | 22.949 | 4441 | 17.241 | 4266 | 1200 | - | - | 48.828 | 12078 |
| 440 | 24.054 | 4655 | 18.088 | 4476 | 1220 | - | - | 49.555 | 12258 |
| 460 | 25.161 | 4869 | 18.938 | 4686 | 1240 | - | - | 50.276 | 12436 |
| 480 | 26.272 | 5084 | 19.788 | 4896 | 1250 | - | - | 50.633 | 12524 |

Table I. Output Voltage vs. Thermocouple Temperature (Ambient $+25^{\circ} \mathrm{C}, V_{S}=-5 \mathrm{~V},+15 \mathrm{~V}$ )

## INTERPRETING AD594/AD595 OUTPUT VOLTAGES

To achieve a temperature proportional output of $10 \mathrm{mV} /{ }^{\circ} \mathrm{C}$ and accurately compensate for the reference junction over the rated operating range of the circuit, the AD594/AD595 is gain trimmed to match the transfer characteristic of J and K type thermocouples at $25^{\circ} \mathrm{C}$. For a type J output in this temperature range the TC is $51.70 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$, while for a type K it is $40.44 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$. The resulting gain for the AD594 is $193.4\left(10 \mathrm{mV} /{ }^{\circ} \mathrm{C}\right.$ divided by $\left.51.7 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}\right)$. and for the AD595 is $247.3\left(10 \mathrm{mV} /{ }^{\circ} \mathrm{C}\right.$ divided by $\left.40.44 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}\right)$. In addition, an absolute accuracy trim induces an input offset to the output amplifier characteristic of $16 \mu \mathrm{~V}$ for the AD594 and $11 \mu \mathrm{~V}$ for the AD595. This offset arises because the AD594/AD595 is trimmed for a 250 mV output while applying a $25^{\circ} \mathrm{C}$ thermocouple input.
Because a thermocouple output voltage is nonlinear with respect to temperature, and the AD594/AD595 linearly amplifies the compensated signal, the following transfer functions should be used to determine the actual output voltages:
AD594 output $=($ Type J Voltage $+16 \mu \mathrm{~V}) \times 193.4$

AD595 output $=($ Type K Voltage $+11 \mu \mathrm{~V}) \times 247.3$ or conversely:
Type J voltage $=($ AD594 output $/ 193.4)-16 \mu \mathrm{~V}$
Type K voltage $=($ AD595 output $/ 247.3)-11 \mu \mathrm{~V}$
Table I above lists the ideal AD594/AD595 output voltages as a function of Celsius temperature for type J and K ANSI standard thermocouples, with the package and reference junction at $25^{\circ} \mathrm{C}$. As is normally the case, these outputs are subject to calibration, gain and temperature sensitivity errors. Output values for intermediate temperatures can be interpolated, or calculated using the output equations and ANSI thermocouple voltage tables referred to zero degrees Celsius. Due to a slight variation in alloy content between ANSI type J and DIN FE-CUNI thermocouples Table I should not be used in conjunction with European standard thermocouples. Instead the transfer function given previously and a DIN thermocouple table should be used. ANSI type $K$ and DIN NICR-Ni thermocouples are composed of identical alloys and exhibit similar behavior. The upper temperature limits in Table I are those recommended for type J and type K thermocouples by the majority of vendors.

## FEATURES

Low Cost
Operates with Type J (AD596) or Type K (AD597) Thermocouples
Built-in Ice Point Compensation
Temperature Proportional Operation - 10mV/ ${ }^{\circ} \mathrm{C}$
Temperature Set-Point Operation - ON/OFF
Programmable Switching Hysteresis
High Impedance Differential Input

## PRODUCT DESCRIPTION

The AD596/AD597 is a monolithic temperature set-point controller which has been optimized for use at elevated temperatures such as those found in oven control applications. The device cold junction compensates and amplifies a type J or K thermocouple input to derive an internal signal proportional to temperature. The internal signal is then compared with an externally applied set-point voltage to yield a low impedance switched output voltage. Dead-Band or switching hysteresis can be programmed using a single external resistor. Alternately, the AD596/ AD597 can be configured to provide a voltage output $\left(10 \mathrm{mV} /{ }^{\circ} \mathrm{C}\right)$ directly from a type J or K thermocouple signal. It can also be used as a stand-alone voltage output temperature sensor.
The AD596/AD597 can be powered with a single supply from +5 V to +30 V , or dual supplies up to a total span of 36 V . Typical quiescent supply current is $160 \mu \mathrm{~A}$ which minimizes self-heating errors.

The AD596/AD597 H package option includes a thermocouple failure alarm that indicates an open thermocouple lead when operated in the temperature proportional measurement mode. The alarm output has a flexible format which can be used to drive relays, LEDs or TTL logic.
The device is packaged in a reliability qualified, cost effective 10 -pin metal can, 8 -pin plastic minidip or SOIC and is trimmed to operate over an ambient temperature range from $+25^{\circ} \mathrm{C}$ to $+100^{\circ} \mathrm{C}$. Operation over an extended ambient temperature range is possible with slightly reduced accuracy. The AD596 will amplify thermocouple signals covering the entire $-200^{\circ} \mathrm{C}$ to $+760^{\circ} \mathrm{C}$ temperature range recommended for type J thermocouples while the AD597 can accommodate $-200^{\circ} \mathrm{C}$ to $+1250^{\circ} \mathrm{C}$ type K inputs.

The AD596/AD597 has a calibration accuracy of $\pm 4^{\circ} \mathrm{C}$ at an ambient temperature of $60^{\circ} \mathrm{C}$ and an ambient temperature stability specification of $0.05^{\circ} \mathrm{C} /{ }^{\circ} \mathrm{C}$ from $+25^{\circ} \mathrm{C}$ to $+100^{\circ} \mathrm{C}$. If higher accuracy, or a lower ambient operating temperature is required, either the AD594 (J thermocouple) or AD595 (K thermocouple) should be considered.

FUNCTIONAL BLOCK DIAGRAMS
TO-100
(H) Package


8-Pin Plastic Mini-DIP (N) Package or SOIC (R) Package


## PRODUCT HIGHLIGHTS

1. The AD596/AD597 provides cold junction compensation and a high gain amplifier which can be used as a set-point comparator.
2. The input stage of the AD596/AD597 is a high quality instrumentation amplifier that allows the thermocouple to float over most of the supply voltage range.
3. Linearization not required for thermocouple temperatures close to $175^{\circ} \mathrm{C}\left(+100^{\circ} \mathrm{C}\right.$ to $+540^{\circ} \mathrm{C}$ for AD 596$)$.
4. Cold junction compensation is optimized for ambient temperatures ranging from $+25^{\circ} \mathrm{C}$ to $+100^{\circ} \mathrm{C}$.
5. In the stand-alone mode, the AD596/AD597 produces an output voltage that indicates its own temperature.
[^255]AD596/AD597 - SPEGIFIGATIONS $\begin{aligned} & \left(@+60^{\circ} \mathrm{C} \text { and } \mathrm{V}_{\mathrm{s}}=10 \mathrm{~V} \text {, Type J (AD596), Type K (AD597) }\right.\end{aligned}$


## NOTES

${ }^{1}$ This is a measure of the deviation from ideal with a measuring thermocouple junction of $175^{\circ} \mathrm{C}$ and a chip temperature of $60^{\circ} \mathrm{C}$. The ideal transfer function is given by:
AD596: $\mathrm{V}_{\text {OUT }}=180.57 \times\left(\mathrm{V}_{\mathrm{m}}-\mathrm{V}_{\mathrm{a}}+\left(\mathrm{ambient}\right.\right.$ in $\left.\left.{ }^{\circ} \mathrm{C}\right) \times 53.21 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}+235 \mu \mathrm{~V}\right)$
AD597: $\mathrm{V}_{\text {OUT }}=245.46 \times\left(\mathrm{V}_{\mathrm{m}}-\mathrm{V}_{\mathrm{a}}+\left(\right.\right.$ ambient in $\left.\left.{ }^{\circ} \mathrm{C}\right) \times 41.27 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}-37 \mu \mathrm{~V}\right)$
where $\mathrm{V}_{\mathrm{m}}$ and $\mathrm{V}_{\mathrm{a}}$ represent the measuring and ambient temperatures and are taken from the appropriate J or K thermocouple table. The ideal transfer function minimizes the error over the ambient temperature range of $25^{\circ} \mathrm{C}$ to $100^{\circ} \mathrm{C}$ with a thermocouple temperature of approximately $175^{\circ} \mathrm{C}$.
${ }^{2}$ Defined as the slope of the line connecting the AD596/AD597 CJC errors measured at $25^{\circ} \mathrm{C}$ and $100^{\circ} \mathrm{C}$ ambient temperature.
${ }^{3}$ Pin 6 shorted to pin 7.
${ }^{4}$ Current Sink Capability in single supply configuration is limited to current drawn to ground through a $50 \mathrm{k} \Omega$ resistor at output voltages below 2.5 V .
${ }^{5}$ Alarm function available on H package option only.
Specifications subject to change without notice.
Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.

## ORDERING GUIDE

| Model | Package Description | Package Option |
| :--- | :--- | :--- |
| AD596AH | TO-100 | H-10A |
| AD597AH | TO-100 | H-10A |
| AD597AN $^{2}$ | Plastic DIP | N-8 |
| AD597AR $^{2}$ | SOIC | R-8 |

## NOTES

${ }^{1}$ For outline information see Package Information section.
${ }^{2}$ Consult factory for availability.

| Thermocouple <br> Temperature ${ }^{\circ} \mathrm{C}$ | Type J <br> Voltage mV | AD596 <br> Output mV | Type K Voltage mV | AD597 <br> Output mV | Thermocouple Temperature ${ }^{\circ} \mathrm{C}$ | Type J Voltage mV | AD596 <br> Output mV | Type K <br> Voltage mV | AD597 <br> Output mV |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| - 200 | - 7.890 | - 1370 | - 5.891 | - 1446 | 500 | 27.388 | 5000 | 20.640 | 5066 |
| - 180 | - 7.402 | -1282 | - 5.550 | - 1362 | 520 | 28.511 | 5203 | 21.493 | 5276 |
| - 160 | - 6.821 | - 1177 | - 5.141 | - 1262 | 540 | 29.642 | 5407 | 22.346 | 5485 |
| - 140 | - 6.159 | - 1058 | - 4.669 | - 1146 | 560 | 30.782 | 5613 | 23.198 | 5694 |
| - 120 | - 5.426 | - 925 | - 4.138 | - 1016 | 580 | 31.933 | 5821 | 24.050 | 5903 |
| - 100 | $-4.632$ | - 782 | - 3.553 | - 872 | 600 | 33.096 | 6031 | 24.902 | 6112 |
| - 80 | - 3.785 , | - 629 | $-2.920$ | - 717 | 620 | 34.273 | 6243 | 25.751 | 6321 |
| - 60 | - 2.892 | - 468 | - 2.243 | - 551 | 640 | 35.464 | 6458 | 26.599 | 6529 |
| - 40 | - 1.960 | - 299 | - 1.527 | - 375 | 660 | 36.671 | 6676 | 27.445 | 6737 |
| - 20 | - . 995 | - 125 | - .777 | - 191 | 680 | 37.893 | 6897 | 28.288 | 6944 |
|  | $-.501$ |  | $-\quad .392$ |  | 700 | 39.130 | 7120 | 29.128 | 7150 |
| $0$ | $0$ | $54$ | $0$ | 0 | 720 | 40.382 | 7346 | 29.965 | 7355 |
| 10 | . 507 | 146 | . 397 | 97 | 740 | 41.647 | 7575 | 30.799 | 7560 |
| 20 | 1.019 | 238 | . 798 | 196 | $750$ | 42.283 | 7689 | $31.214$ | $7662$ |
| 25 | 1.277 | 285 | 1.000 | 245 | $760$ | - | - | $31.629$ | $7764$ |
| 30 | 1.536 | 332 | 1.203 | 295 | 780 | - | - | 32.455 | 7966 |
| 40 | 2.058 | 426 | 1.611 | 395 | 800 | - | - | 33.277 | 8168 |
| 50 | 2.585 | 521 | 2.022 | 496 | 820 | - | - | 34.095 | 8369 |
| 60 | 3.115 | 617 | 2.436 | 598 | 840 | - | - | 34.909 | 8569 |
| 80 | 4.186 | 810 | 3.266 | 802 | 860 | - | - | 35.718 | 8767 |
| 100 | 5.268 | 1006 | 4.095 | 1005 | 880 | - | - | 36.524 | 8965 |
| 120 | 6.359 | 1203 | 4.919 | 1207 | 900 | -- | _ | 37.325 | 9162 |
| 140 | 7.457 | 1401 | 5.733 | 1407 | 920 | - | - | 38.122 | 9357 |
| 160 | 8.560 | 1600 | 6.539 | 1605 | 940 | - | - | 38.915 | 9552 |
| 180 | 9.667 | 1800 | 7.338 | 1801 | 960 | - | - | 39.703 | 9745 |
| 200 | 10.777 | 2000 | 8.137 | 1997 | 980 | - | - | 40.488 | 9938 |
| 220 | 11.887 | 2201 | 8.938 | 2194 | 1000 | - | - | 41.269 | 10130 |
| 240 | 12.998 | 2401 | 9.745 | 2392 | 1020 | - | - | 42.045 | 10320 |
| 260 | 14.108 | 2602 | 10.560 | $2592$ | $1040$ | - | - | 42.817 | 10510 |
| 280 | 15.217 | 2802 | 11.381 | 2794 | 1060 | - | - | 43.585 | 10698 |
|  | 16.325 | 3002 | 12.207 | 2996 |  | - | - | 44.439 | 10908 |
| 320 | 17.432 | 3202 | 13.039 | 3201 | 1100 | - | -- | 45.108 | 11072 |
| 340 | 18.537 | 3402 | 13.874 | 3406 | 1120 | _ | - | 45.863 | 11258 |
| 360 | 19.640 | 3601 | 14.712 | 3611 | 1140 | - | - | 46.612 | 11441 |
| 380 | 20.743 | 3800 | 15.552 | 3817 | 1160 | - | - | 47.356 | 11624 |
| 400 | 21.846 | 3999 | 16.395 | 4024 | 1180 | - | - | 48.095 | 11805 |
| 420 | 22.949 | 4198 | 17.241 | 4232 | 1200 | - | - | 48.828 | 11985 |
| 440 | 24.054 | 4398 | 18.088 | 4440 | 1220 | - | - | 49.555 | 12164 |
| 460 | 25.161 | 4598 | 18.938 | 4649 | 1240 | - | _ | 50.276 | 12341 |
| 480 | 26.272 | 4798 | 19.788 | 4857 | 1250 | - | - | 50.633 | 12428 |

Table I. Output Voltage vs. Thermocouple Temperature (Ambient $+60^{\circ} \mathrm{C}, V_{s}=-5 \mathrm{~V},+15 \mathrm{~V}$ )

## TEMPERATURE PROPORTIONAL OUTPUT MODE

The AD596/AD597 can be used to generate a temperature proportional output of $10 \mathrm{mV} /{ }^{\circ} \mathrm{C}$ when operated with J and K type thermocouples as shown in Figure 1. Thermocouples produce low level output voltages which are a function of both the temperature being measured and the reference or cold junction temperature. The AD596/AD597 compensates for the cold junction temperature and amplifies the thermocouple signal to produce a high level $10 \mathrm{mV} /{ }^{\circ} \mathrm{C}$ voltage output which is a function only of the temperature being measured. The temperature stability of the part indicates the sensitivity of the output voltage to changes in ambient or device temperatures. This is typically $0.02^{\circ} \mathrm{C} /{ }^{\circ} \mathrm{C}$ over the $+25^{\circ} \mathrm{C}$ to $+100^{\circ} \mathrm{C}$ recommended ambient temperature range. The parts will operate over the extended ambient temperature ranges from $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$, but thermocouple nonlinearity at the reference junction will degrade the temperature stability over this extended range. Table I is a list of ideal AD596/ AD597 output voltages as a function of Celsius temperature for type J and K ANSI standard thermocouples with package and reference junction at $60^{\circ} \mathrm{C}$. As is normally the case, these outputs


Figure 1. Temperature Proportional Output Connection
are subject to calibration and temperature sensitivity errors.
These tables are derived using the ideal transfer functions:
AD596 output $=($ Type J voltage $+301.5 \mu \mathrm{~V}) \times 180.57$
AD597 output $=($ Type $K$ voltage $) \times 245.46$

## FEATURES

Instrumentation Amplifier Front End<br>Loop-Powered Operation<br>Precalibrated 30 mV or $\mathbf{6 0 m V}$ Input Spans Independently Adjustable Output Span and Zero<br>Precalibrated Output Spans: 4-20mA Unipolar 0-20mA Unipolar $12 \pm 8 \mathrm{~mA}$ Bipolar<br>\section*{Precalibrated $100 \Omega$ RTD Interface}<br>6.2V Reference with Up to 3.5 mA of Current Available<br>Uncommitted Auxiliary Amp for Extra Flexibility<br>Optional External Pass Transistor to Reduce Self-Heating Errors

## PRODUCT DESCRIPTION

The AD693 is a monolithic signal conditioning circuit which accepts low-level inputs from a variety of transducers to control a standard $4-20 \mathrm{~mA}$, two-wire current loop. An on-chip voltage reference and auxiliary amplifier are provided for transducer excitation; up to 3.5 mA of excitation current is available when the device is operated in the loop-powered mode. Alternatively, the device may be locally powered for three-wire applications when $0-20 \mathrm{~mA}$ operation is desired.
Precalibrated 30 mV and 60 mV input spans may be set by simple pin strapping. Other spans from 1 mV to 100 mV may be realized with the addition of external resistors. The auxiliary amplifier may be used in combination with on-chip voltages to provide six precalibrated ranges for $100 \Omega$ RTDs. Output span and zero are also determined by pin strapping to obtain the standard ranges: $4-20 \mathrm{~mA}, 12 \pm 8 \mathrm{~mA}$ and $0-20 \mathrm{~mA}$.

Active laser trimming of the AD693's thin-film resistors result in high levels of accuracy without the need for additional adjustments and calibration. Total unadjusted error is tested on every device to be less than $0.5 \%$ of full scale at $+25^{\circ} \mathrm{C}$, and less than $0.75 \%$ over the industrial temperature range. Residual nonlinearity is under $0.05 \%$. The AD693 also allows for the use of an external pass transistor to further reduce errors caused by self-heating.
For transmission of low-level signals from RTDs, bridges and pressure transducers, the AD693 offers a cost-effective signal conditioning solution. It is recommended as a replacement for discrete designs in a variety of applications in process control, factory automation and system monitoring.
The AD693 is packaged in a 20 -pin ceramic side-brazed DIP, 20 -pin Cerdip, and 20-pin LCCC and is specified over the $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ industrial temperature range.

## FUNCTIONAL BLOCK DIAGRAM



## PRODUCT HIGHLIGHTS

1. The AD693 is a complete monolithic low-level voltage-tocurrent loop signal conditioner.
2. Precalibrated output zero and span options include $4-20 \mathrm{~mA}, 0-20 \mathrm{~mA}$, and $12 \pm 8 \mathrm{~mA}$ in two- and three-wire configurations.
3. Simple resistor programming adds a continuum of ranges to the basic 30 mV and 60 mV input spans.
4. The common-mode range of the signal amplifier input extends from ground to near the device's operating voltage.
5. Provision for transducer excitation includes a 6.2 V reference output and an auxiliary amplifier which may be configured for voltage or current output and signal amplification.
6. The circuit configuration permits simple linearization of bridge, RTD, and other transducer signals.
7. A monitored output is provided to drive an external pass transistor. This feature off-loads power dissipation to extend the temperature range of operation, enhance reliability, and minimize self-heating errors.
8. Laser-wafer trimming results in low unadjusted errors and affords precalibrated input and output spans.
9. Zero and span are independently adjustable and noninteractive to accommodate transducers or user defined ranges.
10. Six precalibrated temperature ranges are available with a $100 \Omega$ RTD via pin strapping.

[^256]$\left(@+25^{\circ} \mathrm{C}\right.$ and $\mathrm{V}_{\mathrm{S}}=+24 \mathrm{~V}$. Input Span $=30 \mathrm{mV}$ or 60 mV , Output Span $=4-20 \mathrm{~mA}$, $R_{L}=250 \Omega, V_{C M}=3.1 \mathrm{~V}$, with external pass transistor unless otherwise noted)

| Model | Conditions | AD693AD/AQ/AE |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max |  |
| LOOP-POWERED OPERATION |  |  |  |  |  |
| TOTAL UNADJUSTEDERROR ${ }^{1,2}$ <br> $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}$ |  |  | $\begin{aligned} & \pm 0.25 \\ & \pm 0.4 \\ & \hline \end{aligned}$ | $\begin{aligned} & \pm 0.5 \\ & \pm 0.75 \end{aligned}$ | \% Full Scale <br> \% Full Scale |
| $100 \Omega$ RTD CALIBRATION ERROR ${ }^{3}$ | (See Fig. 17) |  | $\pm 0.5$ | $\pm 2.0$ | ${ }^{\circ} \mathrm{C}$ |
| LOOP POWERED OPERATION ${ }^{2}$ |  |  |  |  |  |
| Zero Current Error ${ }^{4}$ | Zero $=4 \mathrm{~mA}$ |  | $\pm 25$ | $\pm 80$ | $\mu \mathrm{A}$ |
|  | Zero $=12 \mathrm{~mA}$ |  | $\pm 40$ | $\pm 120$ | $\mu \mathrm{A}$ |
|  | Zero $=0 \mathrm{~mA}^{5}$ | + 7 | +35 | +100 |  |
| vs. Temp. | Zero $=4 \mathrm{~mA}$ |  | $\pm 0.5$ | $\pm 1.5$ | $\mu \mathrm{A} /{ }^{\circ} \mathrm{C}$ |
| Power Supply Rejection (RTI) | $\begin{aligned} & 12 \mathrm{~V} \leq \mathrm{V}_{\mathrm{OP}} \leq 36 \mathrm{~V}^{6} \\ & 0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CM}} \leq 6.2 \mathrm{~V} \end{aligned}$ |  | $\pm 3.0$ | $\pm 5.6$ | $\mu \mathrm{V} / \mathrm{V}$ |
| Common-Mode Input Range | (See Fig. 3) | 0 |  | $+\mathrm{V}_{\mathrm{OP}}-4 \mathrm{~V}^{6}$ | V |
|  | $0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CM}} \leq 6.2 \mathrm{~V}$ |  | $\pm 10$ | $\pm 30$ | $\mu \mathrm{V} / \mathrm{V}$ |
| Input Bias Current ${ }^{7}$ |  |  | +5 | $+20$ |  |
| $\mathrm{T}_{\min }$ to $\mathrm{T}_{\text {max }}$ |  |  | +7 | $+25$ | nA |
| Input Offset Current ${ }^{7}$ | $\mathrm{V}_{\text {SIG }}=0$ |  | $\pm 0.5$ | $\pm 3.0$ | nA |
| Transconductance |  |  |  |  |  |
| Nominal | 60mV Input Span |  | 0.5333 0.2666 |  | $\mathrm{A} / \mathrm{V}$ |
| vs. Common-Mode |  |  | $\pm 0.05$ | $\pm 0.2$ | \% |
|  | $\left\lvert\, \begin{aligned} & 0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CM}} \leq 6.2 \mathrm{~V} \\ & 30 \mathrm{mV} \text { Input Span } \end{aligned}\right.$ |  | $\pm 0.03$ | $\pm 0.04$ | \%/V |
|  | 60mV Input Span |  | $\pm 0.05$ | $\pm 0.06$ | \%/V |
| Errorvs. Temp. Nonlinearity ${ }^{8}$ |  |  | $\pm 20$ | $\pm 50$ | ppm/ $/{ }^{\circ} \mathrm{C}$ |
|  | 30 mV Input Span |  | $\pm 0.01$ | $\pm 0.05$ | \% of Span |
|  | 60 mV Input Span |  | $\pm 0.02$ | $\pm 0.07$ | $\%$ of Span |
| OPERATIONAL VOLTAGE RANGE |  |  |  |  |  |
| Operational Voltage, $\mathrm{V}_{\text {OP }}{ }^{6}$Quiescent Current |  | +12 |  | +36 | V |
|  | Into Pin 9 |  | $+500$ | +700 | $\mu \mathrm{A}$ |
| OUTPUT CURRENT LIMIT |  | +21 | +25 | +32 | mA |
| COMPONENTS OF ERROR |  |  |  |  |  |
| SIGNAL AMPLIFIER ${ }^{9}$ |  |  |  |  |  |
| Input Voltage Offsetvs. Temp |  |  | $\pm 40$ | $\pm 200$ | $\mu \mathrm{V}$ |
|  |  |  | $\pm 1.0$ | $\pm 2.5$ | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Power Supply Rejection | $\begin{aligned} & 12 \mathrm{~V} \leq \mathrm{V}_{\mathrm{OP}} \leq 36 \mathrm{~V}^{6} \\ & 0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CM}} \leq 6.2 \mathrm{~V} \end{aligned}$ |  | $\pm 3.0$ | $\pm 5.6$ | $\mu \mathrm{V} / \mathrm{V}$ |
| V/I CONVERTER ${ }^{9,10}$ |  |  |  |  |  |
| Zero Current Error | Output Span $=4-20 \mathrm{~mA}$ |  | $\pm 30$ | $\pm 80$ |  |
| Power Supply Rejection | $12 \mathrm{~V} \leq \mathrm{V}_{\mathrm{OP}} \leq 36 \mathrm{~V}^{6}$ |  | $\pm 1.0$ | $\pm 3.0$ | $\mu \mathrm{A} / \mathrm{V}$ |
| Transconductance ${ }^{\text {a }}$ ( ${ }^{\text {a }}$ |  |  |  |  |  |
| Nominal |  |  | 0.2666 |  | A/V |
| Unadjusted Error |  |  | $\pm 0.05$ | $\pm 0.2$ |  |
| 6.200V REFERENCE ${ }^{9,12}$ |  |  |  |  |  |
| Output Voltage Tolerance vs. Temp. |  |  | $\pm 3$ | $\pm 12$ | mV |
|  |  |  | $\pm 20$ | $\pm 50$ | $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ |
| Line Regulation | $12 \mathrm{~V} \leq \mathrm{V}_{\mathrm{OP}} \leq 36 \mathrm{~V}^{6}$ |  | $\pm 200$ | $\pm 300$ | $\mu \mathrm{V} / \mathrm{V}$ |
| Load Regulation ${ }^{11}$ | $0 \mathrm{~mA} \leq \mathrm{I}_{\text {REF }} \leq 3 \mathrm{~mA}$ |  | $\pm 0.3$ | $\pm 0.75$ | $\mathrm{mV} / \mathrm{mA}$ |
| Output Current ${ }^{13}$ | Loop Powered, (Fig. 10) | +3.0 | +3.5 |  | mA |
|  | 3-Wire Mode, (Fig. 15) |  | +5.0 |  | mA |


| Model | Conditions | AD693AD |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| AUXILIARY AMPLIFIER |  |  |  |  |  |
| Common-Mode Range |  | 0 |  | $+\mathrm{V}_{\text {OP }}-4 \mathrm{~V}^{6}$ | V |
| Input Offset Voltage |  |  | $\pm 50$ | $\pm 200$ | $\mu \mathrm{V}$ |
| Input Bias Current |  |  | +5 | +20 | nA |
| Input Offset Current |  |  | +0.5 | $\pm 3.0$ | nA |
| Common-Mode Rejection |  |  | 90 |  | dB |
| Power Supply Rejection |  |  | 105 |  | dB |
| Output Current Range | $\operatorname{Pin} \mathrm{I}_{\mathrm{X}}$ OUT | +0.01 |  | +5 | mA |
| Output Current Error | $\operatorname{Pin} \mathrm{V}_{\mathbf{x}}-\operatorname{Pin} \mathrm{I}_{\mathbf{X}}$ |  | $\pm 0.005$ |  | \% |
| TEMPERATURE RANGE |  |  |  |  |  |
| Case Operating ${ }^{14}$ | $\mathrm{T}_{\min }$ to $\mathrm{T}_{\text {max }}$ | -40 |  | +85 | ${ }^{\circ} \mathrm{C}$ |
| Storage |  | -65 |  | +150 | ${ }^{\circ} \mathrm{C}$ |

NOTES
${ }^{1}$ Total error can be significantly reduced (typically less than $0.1 \%$ ) by trimming the zero current. The remaining unadjusted error sources are transconductance and nonlinearity.
${ }^{2}$ The AD693 is tested as a loop powered device with the signal amp, V/I converter, voltage reference, and application voltages operating together. Specifications are valid for preset spans and spans between 30 mV and 60 mV .
${ }^{3}$ Error from ideal output assuming a perfect $100 \Omega$ RTD at 0 and $+100^{\circ} \mathrm{C}$.
${ }^{4}$ Refer to the Error Analysis to calculate zero current error for input spans less than 30 mV .
${ }^{5}$ By forcing the differential signal amplifier input sufficiently negative the $7 \mu \mathrm{~A}$ zero current can always be achieved.
${ }^{6}$ The operational voltage ( $\mathrm{V}_{\mathrm{OP}}$ ) is the voltage directly across the AD693 (Pin 10 to 6 in two-wire mode, Pin 9 to 6 in local power mode). For example, $\mathrm{V}_{\mathrm{OP}}=\mathrm{V}_{\mathrm{S}}-\left(\mathrm{I}_{\mathrm{LooP}} \times \mathrm{R}_{\mathrm{L}}\right)$ in two-wire mode (refer to Figure 10).
${ }^{7}$ Bias currents are not symmetrical with input signal level and flow out of the input pins. The input bias current of the inverting input increases with input signal voltage, see Figure 2.
${ }^{8}$ Nonlinearity is defined as the deviation of the output from a straight line connecting the endpoints as the input is swept over a 30 mV and 60 mV input span.
${ }^{9}$ Specifications for the individual functional blocks are components of error that contribute to, and that are included in, the Loop Powered Operation specifications.
${ }^{10}$ Includes error contributions of $V / I$ converter and Application Voltages.
${ }^{11}$ Changes in the reference output voltage due to load will affect the Zero Current. A $1 \%$ change in the voltage reference output will result in an error of $1 \%$ in the value of the Zero Current.
${ }^{12}$ If not used for external excitation, the reference should be loaded by approximately 1 mA ( $6.2 \mathrm{k} \Omega$ to common).
${ }^{13}$ In the loop powered mode up to 5 mA can be drawn from the reference, however, the lower limit of the output span will be increased accordingly. 3.5 mA is the maximum current the reference can source while still maintaining a 4 mA zero.
${ }^{14}$ The AD693 is tested with a pass transistor so $\mathrm{T}_{\mathrm{A}} \cong \mathrm{T}_{\mathrm{C}}$.
Specifications subject to change without notice.
Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.

## ABSOLUTE MAXIMUM RATINGS

Supply Voltage . . . . . . . . . . . . . . . . . . . . . +36V
Reverse Loop Current . . . . . . . . . . . . . . . . . . 200 mA
Signal Amp Input Range . . . . . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{OP}}$
Reference Short Circuit to Common . . . . . . . . Indefinite
Auxiliary Amp Input Voltage Range . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{OP}}$
Auxiliary Amp Current Output . . . . . . . . . . . . . 10 mA
Storage Temperature . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature, 10sec Soldering . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Max Junction Temperature . . . . . . . . . . . . . . $+150^{\circ} \mathrm{C}$
ORDERING GUIDE

| Model | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- |
| AD693AD | Ceramic Side-Brazed DIP | D-20 |
| AD693AQ | Cerdip | Q-20 |
| AD693AE | Leadless Ceramic Chip <br>  <br> Carrier(LCCC) | E-20A |

*For outline information see Package Information section.

## AD693 PIN CONFIGURATION (AD, AW, AE Packages)



Functional Diagram


Figure 1. Maximum Load Resistance vs. Power Supply


Figure 2. Differential Input Current vs. Input Signal Voltage Normalized to + IN


Figure 3. Maximum Common-Mode Voltage vs. Supply


Figure 4. Bandwidth vs. Series Load Resistance


Figure 5. Signal Amplifier PSRR vs. Frequency


Figure 6. CMRR (RTI) vs. Frequency


Figure 7. Input Current Noise vs. Frequency


Figure 8. Input Voltage Noise vs. Frequency

## FUNCTIONAL DESCRIPTION

The operation of the AD693 can be understood by dividing the circuit into three functional parts (see Figure 9). First, an instrumentation amplifier front-end buffers and scales the low-level input signal. This amplifier drives the second section, a V/I converter, which provides the $4-$ to -20 mA loop current. The third section, a voltage reference and resistance divider, provides application voltages for setting the various "live zero" currents. In addition to these three main sections, there is an on-chip auxiliary amplifier which can be used for transducer excitation.

## VOLTAGE-TO-CURRENT (V/I) CONVERTER

The output NPN transistor for the V/I section sinks loop current when driven on by a high gain amplifier at its base. The input for this amplifier is derived from the difference in the outputs of the matched preamplifiers having gains, G2. This difference is caused to be small by the large gain, +A , and the negative feedback through the NPN transistor and the loop current sampling resistor between $\mathrm{I}_{\text {IN }}$ and Boost. The signal across this resistor is compared to the input of the left preamp and servos the loop current until both signals are equal. Accurate voltage-tocurrent transformation is thereby assured. The preamplifiers employ a special design which allows the active feedback amplifier to operate from the most positive point in the circuit, $\mathrm{I}_{\mathrm{IN}}$.
The V/I stage is designed to have a nominal transconductance of $0.2666 \mathrm{~A} / \mathrm{V}$. Thus, a 75 mV signal applied to the inputs of the V/I (Pin 16, noninverting; Pin 12, inverting) results in a full-scale output current of 20 mA .

The current limiter operates as follows: the output of the feedback preamp is an accurate indication of the loop current. This output is compared to an internal setpoint which backs off the drive to the NPN transistor when the loop current approaches 25 mA . As a result, the loop and the AD693 are protected from the consequences of voltage overdrive at the $\mathrm{V} / \mathrm{I}$ input.

## VOLTAGE REFERENCE AND DIVIDER

A stabilized bandgap voltage reference and laser-trimmed resistor divider provide for both transducer excitation as well as precalibrated offsets for the V/I converter. When not used for external excitation, the reference should be loaded by approximately 1 mA ( $6.2 \mathrm{k} \Omega$ to common).
The 4 mA and 12 mA taps on the resistor divider correspond to -15 mV and -45 mV , respectively, and result in a live zero of 4 mA or 12 mA of loop current when connected to the V/I converter's
inverting input (Pin 12). Arranging the zero offset in this way makes the zero signal output current independent of input span. When the input to the signal amp is zero, the noninverting input of the $\mathrm{V} / \mathrm{I}$ is at 6.2 V .
Since the standard offsets are laser trimmed at the factory, adjustment is seldom necessary except to accommodate the zero offset of the actual source. (See "Adjusting Zero".)

## SIGNAL AMPLIFIER

The Signal Amplifier is an instrumentation amplifier used to buffer and scale the input to match the desired span. Inputs applied to the Signal Amplifier (at Pins 17 and 18) are amplified and referred to the 6.2 V reference output in much the same way as the level translation occurs in the V/I converter. Signals from the two preamplifiers are subtracted, the difference is amplified, and the result is fed back to the upper preamp to minimize the difference. Since the two preamps are identical, this minimum will occur when the voltage at the upper preamp just matches the differential input applied to the Signal Amplifier at the left.
Since the signal which is applied to the V/I is attenuated across the two $800 \Omega$ resistors before driving the upper preamp, it will necessarily be an amplified version of the signal applied between Pins 17 and 18. By changing this attenuation, you can control the span referred to the Signal Amplifier. To illustrate: a 75 mV signal applied to the $V / I$ results in a 20 mA loop current. Nominally, 15 mV is applied to offset the zero to 4 mA leaving a 60 mV range to correspond to the span. And, since the nominal attenuation of the resistors connected to Pins 16,15 and 14 is 2.00 , a 30 mV input signal will be doubled to result in 20 mA of loop current. Shorting Pins 15 and 16 results in unity gain and permits a 60 mV input span. Other choices of span may be implemented with user supplied resistors to modify the attenuation. (See section "Adjusting Input Span".)
The Signal Amplifier is specially designed to accommodate a large common-mode range. Common-mode signals anywhere up to and beyond the 6.2 V reference are easily handled as long as $\mathrm{V}_{\text {IN }}$ is sufficiently positive. The Signal Amplifier is biased with respect to $\mathrm{V}_{\text {IN }}$ and requires about 3.5 volts of headroom. The extended range will be useful when measuring sensors driven, for example, by the auxiliary amplifier which may go above the 6.2 V potential. In addition, the PNP input stage will continue. to operate normally with common-mode voltages of several hundred mV , negative, with respect to common. This feature accommodates self-generating sensors, such as thermocouples,


Figure 9. Minimal Connection for $0-30 \mathrm{mV}$ Unipolar Input, 4-20mA Output
which may produce small negative normal-mode signals as well as common-mode noise on "grounded" signal sources.

## AUXILIARY AMPLIFIER

The Auxiliary Amplifier is included in the AD693 as a signal conditioning aid. It can be used as an op amp in noninverting applications and has special provisions to provide a controlled current output. Designed with a differential input stage and an unbiased Class A output stage, the amplifier can be resistively loaded to common with the self-contained $100 \Omega$ resistor or with a user supplied resistor.
As a functional element, the Auxiliary Amplifier can be used in dynamic bridges and arrangements such as the RTD signal conditioner shown in Figure 17. It can be used to buffer, amplify and combine other signals with the main Signal Amplifier. The Auxiliary Amplifier can also provide other voltages for excitation if the 6.2 V of the reference is unsuitable. Configured as a simple follower, it can be driven from a user supplied voltage divider or the precalibrated outputs of the AD693 divider (Pins 3 and 4) to provide a stiff voltage output at less than the 6.2 level, or by incorporating a voltage divider as feedback around the amplifier, one can gain-up the reference to levels higher than 6.2 V . If large positive outputs are desired, $\mathrm{I}_{\mathbf{X}}$, the Auxiliary Amplifier output current supply, should be strapped to either $\mathrm{V}_{\text {IN }}$ or

Boost. Like the Signal Amplifier, the Auxiliary requires about 3.5 V of headroom with respect to $\mathrm{V}_{\text {IN }}$ at its input and about 2 V of difference between $I_{X}$ and the voltage to which $V_{X}$ is required to swing.

The output stage of the Auxiliary Amplifier is actually a high gain Darlington transistor where $I_{X}$ is the collector and $V_{X}$ is the emitter. Thus, the Auxiliary Amplifier can be used as a V/I converter when configured as a follower and resistively loaded. $\mathrm{I}_{\mathrm{X}}$ functions as a high-impedance current source whose current is equal to the voltage at $\mathrm{V}_{\mathbf{x}}$ divided by the load resistance. For example, using the onboard $100 \Omega$ resistor and the 75 mV or 150 mV application voltages, either a $750 \mu \mathrm{~A}$ or 1.5 mA current source can be set up for transducer excitation.
The $I_{X}$ terminal has voltage compliance within $2 V$ of $V_{X}$. If the Auxiliary Amplifier is not to be used, then Pin 2, the noninverting input, should be grounded.

## REVERSE VOLTAGE PROTECTION FEATURE

In the event of a reverse voltage being applied to the AD693 through a current-limited loop (limited to 200 mA ), an internal shunt diode protects the device from damage. This protection mode avoids the compliance voltage penalty which results from a series diode that must be added if reversal protection is required in high-current loops.

## APPLICATION EXAMPLES



Figure 10. 0 to $104^{\circ} \mathrm{C}$ Direct Three-Wire $100 \Omega$ RTD Interface, 4-20 mA Output


Figure 11. Thermocouple Inputs with Cold Junction Compensation.

FEATURES
4-20 mA, 0-20 mA Output Ranges
Precalibrated Input Ranges:
0 V to $2 \mathrm{~V}, 0 \mathrm{~V}$ to 10 V
Precision Voltage Reference
Programmable to 2.000 V or 10.000 V
Single or Dual Supply Operation
Wide Power Supply Range: +4.5 V to +36 V
Wide Output Compliance
Input Buffer Amplifier
Open-Loop Alarm
Optional External Pass Transistor to Reduce Self-Heating Errors
0.002\% typ Nonlinearity

## PRODUCT DESCRIPTION

The AD694 is a monolithic current transmitter that accepts high level signal inputs to drive a standard $4-20 \mathrm{~mA}$ current loop for the control of valves, actuators, and other devices commonly used in process control. The input signal is buffered by an input amplifier that can be used to scale the input signal or buffer the output from a current mode DAC. Precalibrated input spans of 0 V to 2 V and 0 V to 10 V are selected by simple pin strapping; other spans may be programmed with external resistor.

The output stage compliance extends to within 2 V of $\mathrm{V}_{\mathrm{S}}$ and its special design allows the output voltage to extend below common in dual supply operation. An alarm warns of an open 4 to 20 mA loop or noncompliance of the output stage.
Active laser trimming of the AD694's thin film resistors results in high levels of accuracy without the need for additional adjustments and calibration. An external pass transistor may be used with the AD694 to off-load power dissipation, extending the temperature range of operation.
The AD694 is the ideal building block for systems requiring noise immune $4-20 \mathrm{~mA}$ signal transmission to operate valves, actuators, and other control devices, as well as for the transmission of process parameters such as pressure, temperature, or flow. It is recommended as a replacement for discrete designs in a variety of applications in industrial process control, factory automation, and system monitoring.
The AD694 is available in hermetically sealed, 16-pin cerdip and plastic SOIC, specified over the $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ industrial temperature range, and in a 16 -pin plastic DIP, specified over the 0 to $+70^{\circ} \mathrm{C}$ temperature range.

## FUNCTIONAL BLOCK DIAGRAM



## PRODUCT HIGHLIGHTS

1. The AD694 is a complete voltage in to $4-20 \mathrm{~mA}$ out current transmitter.
2. Pin programmable input ranges are pre-calibrated at 0 V to 2 V and 0 V to 10 V .
3. The input amplifier may be configured to buffer and scale the input voltage, or to serve as an output amplifier for current output DACs.
4. The output voltage compliance extends to within 2 V of the positive supply and below common. When operated with a 5 V supply, the output voltage compliance extends 30 V below common.
5. The AD694 interfaces directly to 8 -, 10 -, and 12 -bit single supply CMOS and bipolar DACs.
6. The 4 mA zero current may be switched on and off with a TTL control pin, allowing $0-20 \mathrm{~mA}$ operation.
7. An open collector alarm warns of loop failure due to open wires or noncompliance of the output stage.
8. A monitored output is provided to drive an external pass transistor. The feature off-loads power dissipation to extend the temperature range of operation and minimize self-heating error.

\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline \multirow[t]{2}{*}{Model} \& \multicolumn{3}{|c|}{AD694JN/AQ/AR} \& \multicolumn{3}{|c|}{AD694BQ/BR} \& \multirow[b]{2}{*}{Units} \\
\hline \& Min \& Typ \& Max \& Min \& Typ \& Max \& \\
\hline \begin{tabular}{l}
INPUT CHARACTERISTICS \\
Input Voltage Range Input Bias Current \\
Either Input, \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) Offset Current, \(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) Offset Current Drift Input Impedance
\end{tabular} \& \[
-0.2
\]
\[
5
\] \& \[
\begin{aligned}
\& \mathrm{V}_{\mathrm{S}}-2.0 \mathrm{~V} \\
\& 1.5 \\
\& \pm 0.1 \\
\& \pm 1.0
\end{aligned}
\] \& \[
\begin{aligned}
\& \mathrm{V}_{\mathrm{s}}-2.5 \mathrm{~V} \\
\& 5 \\
\& \pm 1 \\
\& \pm 5.0
\end{aligned}
\] \& \[
-0.2
\]
\[
5
\] \& \[
\begin{aligned}
\& \mathrm{V}_{\mathrm{S}}-2.0 \mathrm{~V} \\
\& 1.5 \\
\& \pm 0.1 \\
\& \pm 1.0
\end{aligned}
\] \& \[
\begin{aligned}
\& \mathrm{V}_{\mathrm{s}}-2.5 \mathrm{~V} \\
\& 5 \\
\& \pm 1 \\
\& \pm 5.0
\end{aligned}
\] \& \[
\begin{array}{|l}
\mathrm{V} \\
\mathrm{nA} \\
\mathrm{nA} \\
\mathrm{pA} /{ }^{\circ} \mathrm{C} \\
\mathrm{M} \Omega
\end{array}
\] \\
\hline \begin{tabular}{l}
OUTPUT CHARACTERISTICS \\
Operating Current Range Specified Performance Output Voltage Compliance Output Impedance, 4-20 mA Current Limit @ \(2 \times\) FS Overdrive Slew Rate
\end{tabular} \& \[
\begin{aligned}
\& 0 \\
\& 4 \\
\& \mathbf{V}_{\mathbf{s}}-36 \mathbf{~ V} \\
\& 40.0 \\
\& 24
\end{aligned}
\] \& \[
\begin{aligned}
\& 50.0 \\
\& 1.3
\end{aligned}
\] \& \[
\begin{aligned}
\& 23 \\
\& 20 \\
\& \mathbf{V}_{\mathrm{s}}-2 \mathrm{~V} \\
\& 44
\end{aligned}
\] \& \[
\begin{aligned}
\& 0 \\
\& 4 \\
\& \mathbf{V}_{\mathbf{S}}-36 \mathbf{V} \\
\& 40.0 \\
\& 24
\end{aligned}
\] \& \[
\begin{aligned}
\& 50.0 \\
\& 1.3
\end{aligned}
\] \& \begin{tabular}{l}
\[
\begin{aligned}
\& 23 \\
\& 20 \\
\& \mathbf{V}_{\mathbf{s}}-2 \mathbf{V}
\end{aligned}
\] \\
44
\end{tabular} \& \begin{tabular}{l}
mA \\
mA \\
V \\
\(M \Omega\) \\
mA \\
\(\mathrm{mA} / \mu \mathrm{s}\)
\end{tabular} \\
\hline \begin{tabular}{l}
SPAN AND ZERO ACCURACY \({ }^{1}\) \\
4 mA Offset Error@0V Input \({ }^{2}\) \\
Error from \(4.000 \mathrm{~mA}, 4 \mathrm{~mA}\) On \\
Error from \(0.000 \mathrm{~mA}, 4 \mathrm{~mA}\) Off \\
\(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) \\
vs. Supply ( \(2 \mathrm{~V} \mathrm{Span} / 10 \mathrm{~V}\) Span) \\
Trim Range, 4 mA Zero \\
Span \\
Nominal Transfer Function \\
Input FS \(=2 \mathrm{~V}\) \\
Input FS \(=10 \mathrm{~V}\) \\
Transfer Function Error from Nom, \\
Input FS \(=2 \mathrm{~V}, 10 \mathrm{~V}\) \\
\(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}\) \\
vs. Supply \\
Nonlinearity \({ }^{3}\) \\
4 mA On: Max Pin 9 Voltage \\
4 mA Off: Min Pin 9 Voltage
\end{tabular} \& 0 2.0
\[
3.0
\] \& \begin{tabular}{l}
\[
\begin{aligned}
\& \pm 10 \\
\& +10 \\
\& \pm 10 \\
\& 0.3 / 0.05
\end{aligned}
\] \\
8.0 \\
1.6
\[
\begin{aligned}
\& \pm 0.1 \\
\& \pm 0.002 \\
\& \pm 0.001 \\
\& \pm 0.005
\end{aligned}
\]
\[
2.5
\]
\end{tabular} \& \[
\begin{aligned}
\& \pm 20 \\
\& +20 \\
\& \pm 40 \\
\& 0.8 / 0.4 \\
\& 4.8 \\
\& \\
\& \\
\& \\
\& \\
\& \pm 0.3 \\
\& \pm 0.005 \\
\& \pm 0.005 \\
\& \pm 0.015 \\
\& 0.8
\end{aligned}
\] \& \begin{tabular}{l}
0 \\
2.0 \\
3.0
\end{tabular} \& \begin{tabular}{l}
\[
\begin{aligned}
\& \pm 5 \\
\& +5 \\
\& \pm 5 \\
\& 0.3 / 0.05
\end{aligned}
\] \\
8.0
\[
1.6
\]
\[
\begin{aligned}
\& \pm 0.05 \\
\& \pm 0.001 \\
\& \pm 0.001 \\
\& \pm 0.001
\end{aligned}
\] \\
2.5
\end{tabular} \& \[
\begin{aligned}
\& \pm 10 \\
\& +10 \\
\& \pm 20 \\
\& 0.8 / 0.4 \\
\& 4.8 \\
\& \\
\& \\
\& \\
\& \\
\& \pm 0.15 \\
\& \pm 0.0025 \\
\& \pm 0.005 \\
\& \pm 0.005 \\
\& 0.8
\end{aligned}
\] \& \begin{tabular}{l}
\(\mu \mathrm{A}\) \\
\(\mu \mathrm{A}\) \\
\(\mu \mathrm{A}\) \\
\(\mu \mathrm{A} / \mathrm{V}\) \\
mA \\
\(\mathrm{mA} / \mathrm{V}\) \\
\(\mathrm{mA} / \mathrm{V}\) \\
\% of Span \\
\(\%\) of Span \(/{ }^{\circ} \mathrm{C}\) \\
\(\%\) of Span/V \\
\(\%\) of Span \\
V \\
V
\end{tabular} \\
\hline \begin{tabular}{l}
VOLTAGE REFERENCE \\
Output Voltage: 10 V Reference \\
Output Voltage: 2 V Reference \\
\(\mathrm{T}_{\text {min }}\) to \(\mathrm{T}_{\text {max }}{ }^{4}\) \\
vs. Load, \(\mathrm{V}_{\text {REF }}=2 \mathrm{~V}, 10 \mathrm{~V}\) \\
vs. Supply, \(\mathrm{V}_{\mathrm{REF}}=2 \mathrm{~V}, 10 \mathrm{~V}\) \\
Output Current \\
Source \\
Sink
\end{tabular} \& \begin{tabular}{l}
\[
\begin{aligned}
\& 9.960 \\
\& 1.992
\end{aligned}
\] \\
5
\end{tabular} \& \[
\begin{aligned}
\& 10.000 \\
\& 2.000 \\
\& 30 \\
\& 0.15 \\
\& \pm 0.001 \\
\& \\
\& 0.2
\end{aligned}
\] \& \[
\begin{aligned}
\& 10.040 \\
\& 2.008 \\
\& 50 \\
\& 0.50 \\
\& \pm 0.005
\end{aligned}
\] \& \begin{tabular}{l}
\[
\begin{aligned}
\& 9.980 \\
\& 1.996
\end{aligned}
\] \\
5
\end{tabular} \& \[
\begin{aligned}
\& 10.000 \\
\& 2.000 \\
\& 20 \\
\& 0.15 \\
\& \pm 0.001 \\
\& \\
\& 0.2
\end{aligned}
\] \& \[
\begin{aligned}
\& 10.020 \\
\& 2.004 \\
\& 30 \\
\& 0.50 \\
\& \pm 0.005
\end{aligned}
\] \& \[
\begin{array}{|l}
\mathrm{V} \\
\mathrm{~V} \\
\mathrm{ppm} /{ }^{\circ} \mathrm{C} \\
\mathrm{mV} / \mathrm{mA} \\
\% / \mathrm{V} \\
\\
\mathrm{~mA} \\
\mathrm{~mA}
\end{array}
\] \\
\hline \begin{tabular}{l}
ALARM CHARACTERISTICS \\
\(\mathrm{V}_{\mathrm{CE}(\mathrm{SAT})} @ 2.5 \mathrm{~mA}\) \\
Leakage Current \\
Alarm Pin Current (Pin 10)
\end{tabular} \& \& \[
\begin{aligned}
\& 0.35 \\
\& 20
\end{aligned}
\] \& \(\pm 1\) \& \& \[
\begin{aligned}
\& 0.35 \\
\& 20
\end{aligned}
\] \& \(\pm 1\) \& V \(\mu \mathrm{A}\) mA \\
\hline \begin{tabular}{l}
POWER REQUIREMENTS \\
Specified Performance Operating Range 2 V FS, \(\mathrm{V}_{\mathrm{REF}}=2 \mathrm{~V}\) \(2 \mathrm{~V}, 10 \mathrm{~V}\) FS, \(\mathrm{V}_{\mathrm{REF}}=2 \mathrm{~V}, 10 \mathrm{~V}\) Quiescent Current, 4 mA Off
\end{tabular} \& \[
\begin{array}{|l|}
\hline 4.5 \\
12.5
\end{array}
\] \& 24

1.5 \& $$
\begin{aligned}
& 36 \\
& 36 \\
& 2.0
\end{aligned}
$$ \& \[

$$
\begin{aligned}
& 4.5 \\
& 12.5
\end{aligned}
$$
\] \& 24

1.5 \& \[
$$
\begin{aligned}
& 36 \\
& 36 \\
& 2.0
\end{aligned}
$$

\] \& | V |
| :--- |
| V |
| V |
| mA | <br>


\hline | TEMPERATURE RANGE |  |
| :---: | :--- |
| Specified Performance ${ }^{5}$ AD694AQ/BQ/AR/BR |  |
|  | AD694JN |
| Operating | AD694AQ/BQ/AR/BR |
|  | AD694JN | \& \[

$$
\begin{aligned}
& -40 \\
& 0 \\
& -55 \\
& -40
\end{aligned}
$$

\] \& \& \[

$$
\begin{aligned}
& +85 \\
& +70 \\
& +125 \\
& +85
\end{aligned}
$$

\] \& \[

$$
\begin{aligned}
& -40 \\
& 0 \\
& -55 \\
& -40
\end{aligned}
$$

\] \& \& \[

$$
\begin{aligned}
& +85 \\
& +70 \\
& +125 \\
& +85
\end{aligned}
$$

\] \& \[

$$
\begin{aligned}
& { }^{\circ} \mathrm{C} \\
& { }^{\circ} \mathrm{C} \\
& { }^{\circ} \mathrm{C} \\
& { }^{\circ} \mathrm{C}
\end{aligned}
$$
\] <br>

\hline
\end{tabular}



## NOTES

${ }^{1}$ The single supply op amps of the AD694, lacking pull down current, may not reach 0.000 V at their outputs. For this reason, span, offset, and nonlinearity are specified with the input amplifiers operating in their linear range. The input voltage used for the tests is 5 mV to 2 V and 5 mV to 10 V for the two precalibrated input ranges. Span and zero accuracy are tested with the buffer amplifier configured as a follower.
${ }^{2}$ Offset at 4 mA out and 0 mA out are extrapolated to 0.000 V input from measurements made at 5 mV and at full scale. See Note 1 .
${ }^{3}$ Nonlinearity is specified as the maximum deviation of the output, as a $\%$ of span, from a straight line drawn through the endpoints of the transfer function.
${ }^{4}$ Voltage reference drift guaranteed by the Box Method. The voltage reference output over temperature will fall inside of a box whose length is determined by the temperature range and whose height is determined by the maximum temperature coefficient multiplied by the temperature span in degrees $C$.
${ }^{5}$ Devices tested at these temperatures with a pass transistor. Allowable temperature range of operation is dependent upon internal power dissipation. Absolute maximum junction and case temperature should not be exceeded. See section: "Power Dissipation Considerations."
${ }^{6}$ Buffer amplifier specs for reference. Buffer amplifier offset and drift already included in Span and Zero accuracy specs above.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS

Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . + 36 V
$\mathrm{V}_{\mathrm{S}}$ to $\mathrm{I}_{\text {Out }}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . +36 V
Input Voltage, (Either Input Pin 2 or 3 ) . . . -0.3 V to +36 V
Reference Short Circuit to Common . . . . . . . . . . . Indefinite
Alarm Voltage, Pin 10 . . . . . . . . . . . . . . . . . . . . . . +36 V
4 mA Adj, Pin 6 . . . . . . . . . . . . . . . . . . . . . . . . . . . +1 V
4 mA On/Off, Pin 9 . . . . . . . . . . . . . . . . . . . . 0 V to 36 V
Storage Temperature Range
AD694Q . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
AD694N, R . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Lead Temperature, 10 sec Soldering . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Maximum Junction Temperature . . . . . . . . . . . . . . . $+150^{\circ} \mathrm{C}$
Maximum Case Temperature
Plastic Package (N, R) . . . . . . . . . . . . . . . . . . $+125^{\circ} \mathrm{C}$
Cerdip Package (Q) . . . . . . . . . . . . . . . . . . . . $+125^{\circ} \mathrm{C}$

Transistor Count: . . . . . . . . . . . . . . . . . . 75 Active Devices
Substrate Connection: . . . . . . . . . . . . . to Com, Pin 5
Thermal Characteristics:
Plastic (N) Package: $\theta_{\mathrm{JC}}=50^{\circ} \mathrm{C} / \mathrm{Watt}$

$$
\theta_{\mathrm{CA}}(\text { Still Air })=85^{\circ} \mathrm{C} / \mathrm{W} \text { att }
$$

Cerdip (Q) Package: $\theta_{\mathrm{JC}}=30^{\circ} \mathrm{C} / \mathrm{W}$ att

$$
\theta_{\mathrm{CA}}(\text { Still Air })=70^{\circ} \mathrm{C} / \mathrm{Watt}
$$

Plastic (R) Package: $\theta_{\mathrm{JC}}=27^{\circ} \mathrm{C} /$ Watt

$$
\theta_{\mathrm{CA}}(\text { Still Air })=73^{\circ} \mathrm{C} / \mathrm{W} \text { att }
$$

## ESD Susceptibility

All pins are rated for a minimum of 4000 V protection, except for Pins 2, 3 and 9 which are rated to survive a minimum of 1500 V. ESD testing conforms to Human Body Model. Always practice ESD prevention.

No pin, other than $\mathrm{I}_{\mathrm{OUT}}$ (11) and $\pm \mathrm{Sig}$ (2), (3) as noted, may be permitted to become more negative than Com (5). No pin may be permitted to become more positive than $\mathrm{V}_{\mathrm{S}}$ (13).

PIN CONFIGURATION (N, R, Q Package)


ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Options |
| :--- | :--- | :--- |
| AD694JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| AD694AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| AD694AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16$ |
| AD694BQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| AD694BR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16$ |

$\star \mathrm{N}=$ Plastic DIP; $\mathbf{Q}=$ Cerdip; $\mathrm{R}=$ SOIC. For outline information see Package Information section.


Typical Minimum Supply Voltage vs. Temperature for 2 V \& 10 V Full Scale


Maximum $R_{L}$ vs. Supply Voltage


Voltage Reference Power Supply Rejection

$I_{\text {Out: }}$ Voltage Compliance vs. Temperature


Figure 1. Functional Block Diagram

## FUNCTIONAL DESCRIPTION

The operation of the AD694 can best be understood by dividing the circuit into three functional parts (see Figure 1). First, a single supply input amplifier buffers the high level, single-ended input signal. The buffer amplifier drives the second section, a voltage to current (V/I) converter, that makes a 0 to 16 mA signal dependent current.

The third section, a voltage reference and offset generator, is responsible for providing the 4 mA offset current signal.

## BUFFER AMPLIFIER

The buffer amplifier is a single supply amplifier that may be used as a unity gain buffer, an output amplifier for a current output D/A converter, or as a gain block to amplify low level signals. The amplifier's PNP input stage has a common-mode range that extends from a few hundred mV below ground to within 2.5 V of $\mathrm{V}_{\mathrm{s}}$. The Class A output of the amplifier appears at Pin 1 (FB). The output range extends from about 1 mV above common to within 2.5 V of $\mathrm{V}_{\mathrm{S}}$ when the amplifier is operated as a follower. The amplifier can source a maxirnum load of $5 \mathrm{k} \Omega$, but can sink only as much as its internal $10 \mathrm{k} \Omega$ pulldown resistor allows.

## V/I CONVERTER

The ground referenced, input signal from the buffer amplifier is converted to a 0 to 0.8 mA current by A 2 and level shifted to the positive supply. A current mirror then multiplies this signal by a factor of 20 to make the signal current of 0 to 16 mA . This technique allows the output stage to drive a load to within 2 V of the positive supply $\left(\mathrm{V}_{\mathrm{s}}\right)$. Amplifier A2 forces the voltage at Pin 1 across resistors R1 and R2 by driving the Darlington transistor, Q2. The high gain Darlington transmits the resistor current to its collector and to R3 ( $900 \Omega$ ). A3 forces the level shifted signal across the $45 \Omega$ resistor to get a current gain of 20. The transfer function of the $\mathrm{V} / \mathrm{I}$ stage is therefore:

$$
I_{O U T}=\left(20 \times V_{(P I N I)}\right) /(R 1+R 2)
$$

resulting in a $0-16 \mathrm{~mA}$ output swing for a $0-10 \mathrm{~V}$ input. Tying Pin 4 (2 V FS) to ground shorts out R2 and results in a 2 V full-scale input for a 16 mA output span.
The output stage of the $\mathrm{V} / \mathrm{I}$ converter is of a unique design that allows the $\mathrm{I}_{\text {OUt }}$ pin to drive a load below the common (substrate) potential of the device. The output transistor can always drive a load to a point 36 V below the positive supply ( $\mathrm{V}_{\mathrm{s}}$ ). An optional NPN pass transistor can be added to transfer most of the power dissipation off-chip, to extend the temperature range of operation.
The output stage is current-limited at approximately 38 mA to protect the output from an overdrive at its inputs. The V/I will allow linear operation to approximately 24 mA . The $\mathrm{V} / \mathrm{I}$ converter also has an open collector alarm (Pin 10) which warns of open-circuit condition at the $\mathrm{I}_{\mathrm{OUT}}$ pin or of attempts to drive the output to a voltage greater than $\mathrm{V}_{\mathrm{S}}-2 \mathrm{~V}$.

## 4 mA OFFSET GENERATOR

This circuit converts a constant voltage from the voltage reference to a constant current of approximately $200 \mu \mathrm{~A}$. This current is summed with the signal current at Pin 14 (BW Adjust), to result in a constant 4 mA offset current at $\mathrm{I}_{\mathrm{OUT}}$. The 4 mA Adj (Pin 6) allows the offset current to be adjusted to any current in the range of 2 mA to 4.8 mA . Pin 9 ( $4 \mathrm{~mA} \mathrm{On} / \mathrm{Off}$ ) can shut off the offset current completely if it is lifted to 3.0 V or more, allowing 0 to 20 mA operation of the AD694. In normal $4-20 \mathrm{~mA}$ operation, Pin 9 is connected to ground.

## VOLTAGE REFERENCE

A 2 V or 10 V voltage reference is available for user applications, selectable by pin-strapping. The 10 V option is available for supply voltages greater than 12.5 V , the 2 V output is available over the whole $4.5 \mathrm{~V}-36 \mathrm{~V}$ power supply range. The reference can source up to 5 mA for user applications. A boost transistor can be added to increase the current drive capability of the 2 V mode.

## APPLYING THE AD694

The AD694 can easily be connected for either dual or single supply operation, to operate from supplies as low as 4.5 V and as high as 36 V . The following sections describe the different connection configurations, as well as adjustment methods.
Table I shows possible connection options.
Table I. Precalibrated Ranges for the AD694

| Input <br> Range | Output <br> Range | Voltage <br> Reference | Min <br> $\mathbf{V}_{\mathbf{s}}$ | Pin 9 | Pin 4 | Pin 8 |
| :--- | :--- | :---: | :--- | :--- | :--- | :--- |
| $0-2 \mathrm{~V}$ | $4-20 \mathrm{~mA}$ | 2 V | 4.5 V | Pin 5 | Pin 5 | Pin 7 |
| $0-10 \mathrm{~V}$ | $4-20 \mathrm{~mA}$ | 2 V | 12.5 V | Pin 5 | Open | Pin 7 |
| $0-2.5 \mathrm{~V}$ | $0-20 \mathrm{~mA}$ | 2 V | 5.0 V | $\geq 3 \mathrm{~V}$ | Pin 5 | Pin 7 |
| $0-12.5 \mathrm{~V}$ | $0-20 \mathrm{~mA}$ | 2 V | 15.0 V | $\geq 3 \mathrm{~V}$ | Open | Pin 7 |
| $0-2 \mathrm{~V}$ | $4-20 \mathrm{~mA}$ | 10 V | 12.5 V | Pin 5 | Pin 5 | Open |
| $0-10 \mathrm{~V}$ | $4-20 \mathrm{~mA}$ | 10 V | 12.5 V | Pin 5 | Open | Open |
| $0-2.5 \mathrm{~V}$ | $0-20 \mathrm{~mA}$ | 10 V | 12.5 V | $\geq 3 \mathrm{~V}$ | Pin 5 | Open |
| $0-12.5 \mathrm{~V}$ | $0-20 \mathrm{~mA}$ | 10 V | 15.0 V | $\geq 3 \mathrm{~V}$ | Open | Open |

## BASIC CONNECTIONS: 12.5 V SINGLE SUPPLY OPERATION WITH 10 V FS

Figure 2 shows the minimal connections required for basic operation with a +12.5 V power supply, 10 V input span, $4-20 \mathrm{~mA}$ output span, and a 10 V voltage reference. The buffer amplifier is connected as a voltage follower to drive the $\mathrm{V} / \mathrm{I}$ converter by connecting FB (Pin 1) to - Sig (Pin 2). 4 mA On/Off (Pin 9) is tied to ground (Pin 5) to enable the 4 mA offset current. The AD694 can drive a maximum load $R_{L}=\left[V_{S}-2 \mathrm{~V}\right] / 20 \mathrm{~mA}$, thus the maximum load with a 12.5 V supply is $525 \Omega$.


Figure 2. Minimal Connections for 0-10 V Single-Ended Input, 4-20 mA Output, 10 V Reference Output

## SELECTING A 2 V FULL-SCALE INPUT

The 2 V full-scale option is selected by shorting Pin 4 (2 V FS) to Pin 5 (Common). The connection should be as short as possible; any parasitic resistance will affect the precalibrated span accuracy.

## SELECTING THE 2 V VOLTAGE REFERENCE

The voltage reference is set to a 2 V output by shorting Pin 7 to Pin 8 ( 10 V Force to 2 V Sense). If desired, the 2 V reference can be set up for remote force and sense connection. Keep in mind that the 2 V Sense line carries a constant current of $100 \mu \mathrm{~A}$ that could cause an offset error over long wire runs. The 2 V reference option can be used with all supply voltages greater than 4.5 V .
An NPN boost transistor can be added in the 2 V mode to increase the current drive capability of the 2 V reference. The 10 V force pin is connected to the base of the NPN, and the NPN emitter is connected to the 2 V sense pin. The minimum $\mathrm{V}_{\mathrm{S}}$ of the part increases by approximately 0.7 V .

### 4.5 V SINGLE SUPPLY OPERATION

For operation with a +4.5 V power supply, the input span and the voltage reference output must be reduced to give the amplifiers their required 2.5 V of head room for operation. This is done by adjusting the AD694 for 2 V full-scale input, and a voltage reference output of 2 V as described above.

## GENERAL DESIGN GUIDELINES

A $0.1 \mu \mathrm{~F}$ decoupling capacitor is recommended in all applications from $\mathrm{V}_{\mathrm{S}}$ (Pin 13) to Com (Pin 5). Additional components may be required if the output load is nonresistive, see section on driving nonresistive loads. The buffer amplifier PNP inputs should not be brought more than -0.3 V of common, or they will begin to source large amounts of current. Input protection resistors must be added to the inputs if there is a danger of this occurring. The output of the buffer amplifier, Pin 1 (FB), is not short circuit protected. Shorting this pin to ground or $\mathrm{V}_{\mathrm{S}}$ with a signal present on the amplifier may damage it. Input signals should not drive Pin 1 (FB) directly; always use the buffer amplifier to buffer input signals.

## DRIVING NONRESISTIVE LOADS

The AD694 is designed to be stable when driving resistive loads. Adding a $0.01 \mu \mathrm{~F}$ capacitor from $\mathrm{I}_{\mathrm{OUT}}$ (Pin 11) to Com (Pin 5), as shown in Figure 3, insures the stability of the AD694 when driving inductive or poorly defined loads. This capacitor is recommended when there is any uncertainty as to the characteristics of the load.


Figure 3. Capacitor Utilized When Driving Nonresistive Loads; Protection Diodes Used When Driving Inductive Loads

Additional protection is recommended when driving inductive loads. Figure 3 shows two protective diodes, D1 and D2, added to protect against voltage spikes that may extend above $\mathrm{V}_{\mathrm{S}}$ or below common that could damage the AD694. These diodes should be used in addition to the $0.01 \mu \mathrm{~F}$ capacitor. When the optional NPN transistor is used, the capacitor and diodes should connect to the NPN emitter instead of Pin 11.

## $0-20 \mathrm{~mA}$ OPERATION

A $0-20 \mathrm{~mA}$ output range is available with the AD694 by removing the 4 mA offset current with the $4 \mathrm{~mA} \mathrm{On} / \mathrm{Off}$ pin. In normal 4-20 mA operation $4 \mathrm{~mA} \mathrm{On} / \mathrm{Off}(\operatorname{Pin} 9)$ is tied to ground, enabling the 4 mA offset current. Tying Pin 9 to a potential of 3 V or greater turns off the 4 mA offset current; connecting Pin 9 to the 10 V reference, the positive supply, or a TTL control pin, is a convenient way to do this. In $0-20 \mathrm{~mA}$ mode the input span is increased by $20 \%$, thus the precalibrated input spans of 2 V and 10 V become 2.5 V and 12.5 V . Minimum supply voltages for the two spans increase to 5 V and 15 V .
The 4 mA On/Off pin may also be used as a "jiggle pin" to unstick valves or actuators, or as a way to shut off a $4-20 \mathrm{~mA}$ loop entirely. Note that the pin only removes the 4 mA offset and not the signal current.

## DUAL SUPPLY OPERATION

Figure 4 shows the AD694 operated in dual supply mode. (Note that the pass transistor is shown for illustration and is not required for dual supply operation.) The device is powered completely by the positive supply which may be as low as 4.5 V . The unique design of the output stage allows the $\mathrm{I}_{\text {OUT }}$ pin to extend below common to a negative supply. The output stage can source a current to a point 36 V below the positive supply. For example, when operated with a +12.5 V supply, the AD694 can source a current to a point as low as 23.5 V below common. This feature can simplify the interface to dual supply D/A converters by eliminating grounding and level-shifting problems while increasing the load that the transmitter is able to drive. Note that the $\mathrm{I}_{\text {Out }}$ pin is the only pin that should be allowed to extend lower than -0.3 V of common.

## OPERATION WITH A PASS TRANSISTOR

The AD694 can operate as a stand-alone $4-20 \mathrm{~mA}$ converter with no additional active components. However, provisions have been made to connect $\mathrm{I}_{\text {OUt }}$ to the base of an external NPN pass transistor as shown in Figure 4. This permits a majority of the power dissipation to be moved off-chip to enhance performance and extend the temperature range of operation. Note that the positive output voltage compliance is reduced by approximately 0.7 V , the $\mathrm{V}_{\mathrm{BE}}$ of the pass device. A $50 \Omega$ resistor should be added in series with the pass transistor collector, when the AD694 is operated with dual supplies, as shown in Figure 4. This will not reduce the voltage compliance of the output stage. The external pass transistor selected should have a $\mathrm{BV}_{\text {CEO }}$ greater than the intended supply voltage with a sufficient power rating for continuous operation with 25 mA current at the supply voltage. Ft should be in the 10 MHz to 100 MHz range and $\beta$ should be greater than 10 at a 20 mA emitter current. Heat sinking the external pass transistor is suggested.


Figure 4. Using Optional Pass Transistor to Minimize SelfHeating Errors; Dual Supply Operation Shown

## APPLICATION EXAMPLE



Figure 5. Low Cost Sensor Transmitter

Voltage Output Temperature Sensor with Signal Conditioning

## FEATURES

$200^{\circ} \mathrm{C}$ Temperature Span
Accuracy Better than $\pm \mathbf{2 \%}$ of Full Scale
Linearity Better than $\pm 1 \%$ of Full Scale
Temperature Coefficient of $\mathbf{2 2 . 5} \mathbf{~ m V} /{ }^{\circ} \mathrm{C}$
Output Proportional to Temperature $\times \mathrm{V}_{+}$
Single Supply Operation
Reverse Voltage Protection
Minimal Self Heating
High Level, Low Impedance Output
APPLICATIONS
HVAC Systems
System Temperature Compensation
Board Level Temperature Sensing
Electronic Thermostats
MARKETS
Industrial Process Control
Instrumentation
Automotive

## GENERAL DESCRIPTION

The AD22100 is a monolithic temperature sensor with on-chip signal conditioning. It can be operated over the temperature range $-50^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$, making it ideal for use in numerous HVAC, instrumentation and automotive applications.
The signal conditioning eliminates the need for any trimming, buffering or linearization circuitry, greatly simplifying the system design and reducing the overall system cost.
The output voltage is proportional to the temperature times the supply voltage (ratiometric). The output swings from 0.25 V at $-50^{\circ} \mathrm{C}$ to +4.75 V at $+150^{\circ} \mathrm{C}$ using a single +5.0 V supply.
Due to its ratiometric nature, the AD22100 offers a cost effective solution when interfacing to an analog-to-digital converter. This is accomplished by using the ADC's +5 V power supply as a reference to both the ADC and the AD22100 (See Figure 1), eliminating the need for and cost of a precision reference.

SIMPLIFIED BLOCK DIAGRAM



Figure 1. Application Circuit

[^257]
## AD22100-SPECIFICATIONS $\left(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right.$ and $\mathrm{V}_{+}=+4 \mathrm{~V}$ to +6 V unless otherwise noted)

|  |  | 22100K |  |  | 22100 |  |  | 22100 |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Parameter | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | Units |
| TRANSFER FUNCTION | $\mathrm{V}_{\text {OUT }}=(\mathrm{V}+/ 5 \mathrm{~V}) \times\left[1.375 \mathrm{~V}+\left(22.5 \mathrm{mV} /{ }^{\circ} \mathrm{C}\right) \times \mathrm{T}_{\mathrm{A}}\right]$ |  |  |  |  |  |  |  |  | V |
| TEMPERATURE COEFFICIENT | $(\mathrm{V}+/ 5 \mathrm{~V}) \times 22.5$ |  |  |  |  |  |  |  |  | $\mathrm{mV} /{ }^{\circ} \mathrm{C}$ |
| TOTAL ERROR <br> Initial Error $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ <br> Error over Temperature $\begin{aligned} & \mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{MIN}} \\ & \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{MAX}} \end{aligned}$ <br> Nonlinearity $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{MIN}} \text { to } \mathrm{T}_{\mathrm{MAX}}$ |  | $\begin{aligned} & \pm 0.5 \\ & \pm 0.75 \\ & \pm 0.75 \end{aligned}$ | $\begin{aligned} & \pm 2.0 \\ & \pm 2.0 \\ & \pm 2.0 \\ & 0.5 \end{aligned}$ |  | $\begin{aligned} & \pm 1.0 \\ & \pm 2.0 \\ & \pm 2.0 \end{aligned}$ | $\begin{aligned} & \pm 2.0 \\ & \pm 3.7 \\ & \pm 3.0 \\ & \\ & 0.5 \end{aligned}$ |  | $\begin{aligned} & \pm 1.0 \\ & \pm 3.0 \\ & \pm 3.0 \end{aligned}$ | $\begin{aligned} & \pm 2.0 \\ & \pm 4.0 \\ & \pm 4.0 \\ & 1.0 \end{aligned}$ | ${ }^{\circ} \mathrm{C}$ <br> ${ }^{\circ} \mathrm{C}$ <br> ${ }^{\circ} \mathrm{C}$ <br> \% FS ${ }^{1}$ |
| OUTPUT CHARACTERISTICS <br> Nominal Output Voltage $\begin{aligned} & \mathrm{V}+=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=0^{\circ} \mathrm{C} \\ & \mathrm{~V}+=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+100^{\circ} \mathrm{C} \\ & \mathrm{~V}+=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C} \\ & \mathrm{~V}+=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+85^{\circ} \mathrm{C} \\ & \mathrm{~V}+=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-50^{\circ} \mathrm{C} \\ & \mathrm{~V}+=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+150^{\circ} \mathrm{C} \end{aligned}$ |  | $\begin{aligned} & 1.375 \\ & 3.625 \end{aligned}$ |  |  | $\begin{aligned} & 0.475 \\ & 3.288 \end{aligned}$ |  |  | $\begin{aligned} & 0.250 \\ & 4.750 \end{aligned}$ |  | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \end{aligned}$ |
| POWER SUPPLY <br> Operating Voltage Quiescent Current | +4.0 | $\begin{aligned} & +5.0 \\ & 500 \end{aligned}$ | $\begin{aligned} & +6.0 \\ & 650 \end{aligned}$ | +4.0 | $\begin{aligned} & +5.0 \\ & 500 \end{aligned}$ | $\begin{aligned} & +6.0 \\ & 650 \end{aligned}$ | +4.0 | $\begin{aligned} & +5.0 \\ & 500 \end{aligned}$ | $\begin{aligned} & +6.0 \\ & 650 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mu \mathrm{~A} \end{aligned}$ |
| TEMPERATURE RANGE Guaranteed Temperature Range Operating Temperature Range | $\begin{gathered} 0 \\ -50 \\ \hline \end{gathered}$ |  | $\begin{aligned} & +100 \\ & +150 \end{aligned}$ | $\begin{aligned} & -40 \\ & -50 \end{aligned}$ |  | $\begin{aligned} & +85 \\ & +150 \end{aligned}$ | $\begin{aligned} & -50 \\ & -50 \end{aligned}$ |  | $\begin{aligned} & +150 \\ & +150 \end{aligned}$ | $\begin{aligned} & { }^{\circ} \mathrm{C} \\ & { }^{\circ} \mathrm{C} \end{aligned}$ |
| PACKAGE | $\begin{aligned} & \text { TO-92 } \\ & \text { SOIC } \end{aligned}$ |  |  | $\begin{aligned} & \text { TO-92 } \\ & \text { SOIC } \end{aligned}$ |  |  | $\begin{aligned} & \text { TO-92 } \\ & \text { SOIC } \end{aligned}$ |  |  |  |

Specifications subject to change without notice.

## CHIP SPECIFICATIONS $\left(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right.$ and $\mathrm{V}_{+}=+5.0 \mathrm{~V}$ unless otherwise noted)

| Parameter | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: |
| TRANSFER FUNCTION | $\mathrm{V}_{\text {OUT }}=(\mathrm{V}+/ 5 \mathrm{~V}) \times\left[1.375+22.5 \mathrm{mV} /{ }^{\circ} \mathrm{C} \times \mathrm{T}_{\mathrm{A}}\right]$ |  |  | V |
| TEMPERATURE COEFFICIENT | $(\mathrm{V}+/ 5 \mathrm{~V}) \times 22.5$ |  |  | $\mathrm{mV} /{ }^{\circ} \mathrm{C}$ |
| OUTPUT CHARACTERISTICS <br> Error $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ <br> Nominal Output Voltage $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |  | $\begin{aligned} & \pm 0.5 \\ & 1.938 \end{aligned}$ | $\pm 2.0$ | ${ }^{\circ} \mathrm{C}$ <br> V |
| POWER SUPPLY Operating Voltage Quiescent Current | +4.0 | $\begin{aligned} & +5.0 \\ & 500 \end{aligned}$ | $\begin{aligned} & +6.0 \\ & 650 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mu \mathrm{~A} \end{aligned}$ |
| TEMPERATURE RANGE Guaranteed Temperature Range Operating Temperature Range | -50 | $25^{\circ} \mathrm{C}$ | +150 | $\begin{aligned} & { }^{\circ} \mathrm{C} \\ & { }^{\circ} \mathrm{C} \end{aligned}$ |

[^258]ABSOLUTE MAXIMUM RATINGS ${ }^{1}$
Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . +10 V
Reversed Continuous Supply Voltage ...................-10 V
Operating Temperature . . . . . . . . . . . . . . . . $-50^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Storage Temperature . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+160^{\circ} \mathrm{C}$
Output Short Circuit to V+ or Ground . . . . . . . . . . . Indefinite
Lead Temperature (Soldering, 10 sec ) . . . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only; the functional operation of the device at these or any other conditions above those indicated in the operation sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## ORDERING GUIDE

|  | Guaranteed <br> Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD22100 KT | $0^{\circ} \mathrm{C}$ to $100^{\circ} \mathrm{C}$ | TO-92 | TO-92 |
| AD22100 KR | $0^{\circ} \mathrm{C}$ to $100^{\circ} \mathrm{C}$ | SOIC | SO-8 |
| AD22100 AT | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | TO-92 | TO-92 |
| AD22100 AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | SOIC | SO-8 |
| AD22100 ST | $-50^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ | TO-92 | TO-92 |
| AD22100 SR | $-50^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ | SOIC | SO-8 |
| AD22100 KChips | $+25^{\circ} \mathrm{C}$ | N/A | N/A |

NOTES
${ }^{1}$ Minimum purchase quantities of 100 pieces for all chip orders.
${ }^{2}$ For outline information see Package Information section.

## PIN DESCRIPTION

| Mnemonic | Function |
| :--- | :--- |
| $\mathrm{V}+$ | Power Supply Input |
| $\mathrm{V}_{\mathrm{O}}$ | Device Output |
| GND | Ground Pin must be connected to 0 V. |
| NC | No Connect |

## PIN CONFIGURATIONS

TO-92


SOIC


## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD22100 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

## Typical Performance Curves



Figure 2. Thermal Response vs. Flow Rate


Figure 3. Thermal Resistance vs. Flow Rate

## THEORY OF OPERATION

The AD22100 is a ratiometric temperature sensor IC whose output voltage is proportional to power supply voltage. The heart of the sensor is a proprietary temperature-dependent resistor, similar to an RTD, which is built into the IC. Figure 4 shows a simplified block diagram of the AD22100.


Figure 4. Simplified Block Diagram
The temperature-dependent resistor, labeled $\mathrm{R}_{\mathrm{T}}$, exhibits a change in resistance that is nearly linearly proportional to temperature. This resistor is excited with a current source that is proportional to power supply voltage. The resulting voltage across $\mathrm{R}_{\mathrm{T}}$ is therefore both supply voltage proportional and linearly varying with temperature. The remainder of the AD22100 consists of an op amp signal conditioning block that takes the voltage across $\mathrm{R}_{\mathrm{T}}$ and applies the proper gain and offset to achieve the following output voltage function:

$$
V_{O U T}=(V+/ 5 V) \times\left[1.375 V+\left(22.5 \mathrm{mV} /^{\circ} \mathrm{C}\right) \times T_{A}\right]
$$

## ABSOLUTE ACCURACY AND NONLINEARITY SPECIFICATIONS

Figure 5 graphically depicts the guaranteed limits of accuracy for the AD22100 and shows the performance of a typical part. As the output is very linear, the major sources of error are offset, i.e., error at room temperature, and span error, i.e., deviation from the theoretical $22.5 \mathrm{mV} /{ }^{\circ} \mathrm{C}$. Demanding applications can achieve improved performance by calibrating these offset and gain errors so that only the residual nonlinearity remains as a significant source of error.


Figure 5. Typical AD22100 Performance

## OUTPUT STAGE CONSIDERATIONS

As previously stated, the AD22100 is a voltage output device. A basic understanding of the nature of its output stage is useful for proper application. Note that at the nominal supply voltage of 5.0 V , the output voltage extends from 0.25 V at $-50^{\circ} \mathrm{C}$ to +4.75 V at $+150^{\circ} \mathrm{C}$. Furthermore, the AD 22100 output pin is capable of withstanding an indefinite short circuit to either ground or the power supply. These characteristics are provided by the output stage structure shown in Figure 6.


Figure 6. Output Stage Structure
The active portion of the output stage is a PNP transistor with its emitter connected to the $\mathrm{V}+$ supply and collector connected to the output node. This PNP transistor sources the required amount of output current. A limited pull-down capability is provided by a fixed current sink of about $-80 \mu \mathrm{~A}$. (Here, "fixed" means the current sink is fairly insensitive to either supply voltage or output loading conditions. The current sink capability is a function of temperature, increasing its pull-down capability at lower temperatures.)
Due to its limited current sinking ability, the AD22100 is incapable of driving loads to the $\mathrm{V}+$ power supply and is instead intended to drive grounded loads. A typical value for short circuit current limit is 7 mA , so devices can reliably source 1 mA or 2 mA . However, for best output voltage accuracy and minimal internal self-heating, output current should be kept below 1 mA . Loads connected to the $\mathrm{V}+$ power supply should be avoided as the current sinking capability of the AD22100 is fairly limited. These considerations are typically not a problem when driving a microcontroller analog to digital converter input pin (see MICROPROCESSOR A/D INTERFACE ISSUES).

## RATIOMETRICITY CONSIDERATIONS

The AD22100 will operate with slightly better accuracy than that listed in the data sheet specifications if the power supply is held constant. This is because the AD22100's output voltage varies with both temperature and supply voltage, with some errors. The ideal transfer function describing the output voltage is:

$$
(V+/ 5 V) \times\left[1.375 V+\left(22.5 m V /{ }^{\circ} \mathrm{C}\right) \times T_{A}\right]
$$

The ratiometricity error is defined as the percent change away from the ideal transfer function as the power supply voltage changes within the operating range of +4 V to +6 V . For the AD22100 this error is typically less than $1 \%$. A movement from the ideal transfer function by $1 \%$ at $+25^{\circ} \mathrm{C}$, with a supply voltage varying from 5.0 V to 5.50 V , results in a 1.94 mV change in output voltage or $0.08^{\circ} \mathrm{C}$ error. This error term is greater at higher temperatures because the output (and error term) is directly proportional to temperature. At $150^{\circ} \mathrm{C}$, the error in output voltage is 4.75 mV or $0.19^{\circ} \mathrm{C}$.

For example, with $\mathrm{V}_{\mathrm{S}}=5.0 \mathrm{~V}$, and $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, the nominal output of the AD 22100 will be 1.9375 V . At $\mathrm{V}_{\mathrm{S}}=5.50 \mathrm{~V}$, the nominal output will be 2.1313 V , an increase of 193.75 mV . A proportionality error of $1 \%$ is applied to the 193.75 mV , yielding an error term of 1.9375 mV . This error term translates to a variation in output voltage of 2.1293 V to 2.3332 V . A 1.94 mV error at the output is equivalent to about $0.08^{\circ} \mathrm{C}$ error in accuracy.
If we substitute $150^{\circ} \mathrm{C}$ for $25^{\circ} \mathrm{C}$ in the above example, then the error term translates to a variation in output voltage of 5.2203 V to 5.2298 V . A 4.75 mV error at the output is equivalent to about $0.19^{\circ} \mathrm{C}$ error in accuracy.

## MOUNTING CONSIDERATIONS

If the AD22100 is thermally attached and properly protected, it can be used in any measuring situation where the maximum range of temperatures encountered is between $-50^{\circ} \mathrm{C}$ and $+150^{\circ} \mathrm{C}$. Because plastic IC packaging technology is employed, excessive mechanical stress must be avoided when fastening the device with a clamp or screw-on heat tab. Thermally conductive epoxy or glue is recommended for typical mounting conditions. In wet or corrosive environments, an electrically isolated metal or ceramic well should be used to shield the AD22100. Because the part has a voltage output (as opposed to current), it offers modest immunity to leakage errors, such as those caused by condensation at low temperatures.

## THERMAL ENVIRONMENT EFFECTS

The thermal environment in which the AD22100 is used determines two performance traits: the effect of self-heating on accuracy and the response time of the sensor to rapid changes in temperature. In the first case, a rise in the IC junction temperature above the ambient temperature is a function of two variables; the power consumption of the AD22100 and the thermal resistance between the chip and the ambient environment $\theta_{\mathrm{JA}}$. Self-heating error in ${ }^{\circ} \mathrm{C}$ can be derived by multiplying the power dissipation by $\theta_{\mathrm{JA}}$. Because errors of this type can vary widely for surroundings with different heat sinking capacities, it is necessary to specify $\theta_{\mathrm{JA}}$ under several conditions. Table I shows how the magnitude of self-heating error varies relative to the environment. A typical part will dissipate about 2.2 mW at room temperature with a 5 V supply and negligible output loading. In still air, without a "heat sink," the table below indicates a $\theta_{\mathrm{JA}}$ of $190^{\circ} \mathrm{C} / \mathrm{W}$, yielding a temperature rise of $0.4^{\circ} \mathrm{C}$. Thermal rise will be considerably less in either moving air or with direct physical connection to a solid (or liquid) body.

Table I. Thermal Resistance (TO-92)

| Medium | $\theta_{\mathrm{JA}}\left({ }^{\circ} \mathbf{C} /\right.$ Watt $)$ | $\tau(\mathbf{s e c}){ }^{\star}$ |
| :--- | :---: | :---: |
| Aluminum Block <br> Moving Air$\star \star$ <br> Without Heat Sink | 60 | 2 |
| Still Air <br> Without Heat Sink | 75 | 3.5 |

[^259]Response of the AD22100 output to abrupt changes in ambient temperature can be modeled by a single time constant $\tau$ exponential function. Figure 7 shows typical response time plots for a few media of interest.


Figure 7. Response Time
The time constant $\tau$ is dependent on $\theta_{\mathrm{JA}}$ and the thermal capacities of the chip and the package. Table I lists the effective $\tau$ (time to reach $63.2 \%$ of the final value) for a few different media. Copper printed circuit board connections were neglected in the analysis; however, they will sink or conduct heat directly through the AD22100's solder plated copper leads. When faster response is required, a thermally conductive grease or glue between the AD22100 and the surface temperature being measured should be used.

## MICROPROCESSOR A/D INTERFACE ISSUES

The AD22100 is especially well suited to providing a low cost temperature measurement capability for microprocessor/ microcontroller based systems. Many inexpensive 8 -bit microprocessors now offer an onboard 8-bit ADC capability at a modest cost premium. Total "cost of ownership" then becomes a function of the voltage reference and analog signal conditioning necessary to mate the analog sensor with the microprocessor ADC. The AD22100 can provide an ideal low cost system by eliminating the need for a precision voltage reference and any additional active components. The ratiometric nature of the AD22100 allows the microprocessor to use the same power supply as its ADC reference. Variations of hundreds of millivolts in the supply voltage have little effect as both the AD22100 and the ADC use the supply as their reference. The nominal AD 22100 signal range of 0.25 V to $4.75 \mathrm{~V}\left(-50^{\circ} \mathrm{C}\right.$ to $\left.+150^{\circ} \mathrm{C}\right)$ makes good use of the input range of a 0 V to 5 V ADC. A single resistor and capacitor are recommended to provide immunity to the high speed charge dump glitches seen at many microprocessor ADC inputs (see Figure 1).
An 8-bit ADC with a reference of 5 V will have a least significant bit (LSB) size of $5 \mathrm{~V} / 256=19.5 \mathrm{mV}$. This corresponds to a nominal resolution of about $0.87^{\circ} \mathrm{C}$.

## AD22100

USE WITH A PRECISION REFERENCE AS THE SUPPLY VOLTAGE
While the ratiometric nature of the AD22100 allows for system operation without a precision voltage reference, it can still be used in such systems. Overall system requirements involving other sensors or signal inputs may dictate the need for a fixed precision ADC reference. The AD22100 can be converted to absolute voltage operation by using a precision reference as the supply voltage. For example, a 5.00 V reference can be used to power the AD22100 directly. Supply current will typically be $500 \mu \mathrm{~A}$ which is usually within the output capability of the reference. A large number of AD 22100 s may require an additional op amp buffer, as would scaling down a 10.00 V reference that might be found in "instrumentation" ADCs typically operating from $\pm 15 \mathrm{~V}$ supplies.

FEATURES
Complete Acceleration Measurement System on a Single Monolithic IC
Full-Scale Measurement Range: $\pm \mathbf{5} \mathbf{g}$
Self-Test on Digital Command
Single Supply Operation: +5 V
Sensitivity Precalibrated to $200 \mathrm{mV} / \mathrm{g}$
Internal Buffer Amplifier for User Adjustable
Span and Zero-g Levels
Frequency Response: DC to $\mathbf{4} \mathbf{k H z}$
Post Filtering with External Passive Components
High Shock Survival: >1000 g Unpowered
Other Accelerometer Products, Measuring Different $g$ Levels, Are Available

## GENERAL DESCRIPTION

The ADXL05 is a low noise member of the ADXL50 family of products. It is a complete acceleration measurement system on a single monolithic IC. Three external capacitors and a +5 volt regulated power supply are all that is required to measure accelerations up to $\pm 5 \mathrm{~g}$. Device sensitivity is factory trimmed to a scale factor of $200 \mathrm{mV} / \mathrm{g}$ resulting in a full-scale output swing of $\pm 1$ volt for $\mathrm{a} \pm 5 \mathrm{~g}$ applied acceleration. Its zero-g output level is +1.8 volts.

A TTL compatible self-test function can electrostatically deflect the sensor beam at any time to verify device functionality.
For convenience, the ADXL05 has an internal buffer amplifier with a full 0.25 V to 4.75 V output range. This may be used to set the zero-g level and change the output sensitivity by using external resistors. External capacitors may be added to the resistor network to provide 1 or 2 poles of filtering. No external active components are required to interface directly to most analog-to-digital converters (ADCs) or microcontrollers.
The ADXL05 uses a capacitive measurement method. The analog output voltage is directly proportional to acceleration and is fully scaled, referenced and temperature compensated, resulting in high accuracy and linearity over a wide temperature range. Internal circuitry implements a forced-balance control loop that improves accuracy by compensating for mechanical sensor variations.

The ADXL 05 is powered from a standard +5 V supply and is robust, allowing its use in harsh industrial and automotive environments. It will survive shocks of 1000 g unpowered. The ADXL05 is available in a hermetic 10 -pin TO- 100 metal can. Contact factory for grades of performance and temperature ranges.

## FUNCTIONAL BLOCK DIAGRAM AND PINOUT



NOTE:
AXIS OF SENSITIVITY IS IN PLANE OF PIN 5 TO TAB.

[^260]This is a preliminary data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

ADXL05-SPECIFICATIONS
$\left(\mathrm{T}_{\mathrm{A}}=+\mathbf{2 5}{ }^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{S}}=+5 \mathrm{~V}\right.$, @ Acceleration $=0 \mathrm{~g}$, unless otherwise noted)


[^261][^262]FEATURES
Complete Acceleration Measurement System on a Single Monolithic IC
Full-Scale Measurement Range: $\mathbf{\pm 5 0} \mathbf{g}$
Self-Test on Digital Command
+5 V Single Supply Operation
Sensitivity Precalibrated to $19 \mathrm{mV} / \mathrm{g}$
Internal Buffer Amplifier for User Adjustable Sensitivity and Zero-g Level
Frequency Response: DC to $\mathbf{1 0} \mathbf{~ k H z}$
Post Filtering with External Passive Components
High Shock Survival: >2000 g Unpowered
Other Versions Available: ADXL05 ( $\pm 5 \mathrm{~g}$ ) ADXL181 (+880 g, -150 g)

## GENERAL DESCRIPTION

The ADXL50 is a complete acceleration measurement system on a single monolithic IC. Three external capacitors and a +5 volt power supply are all that is required to measure accelerations up to $\pm 50 \mathrm{~g}$. Device sensitivity is factory trimmed to $19 \mathrm{mV} / \mathrm{g}$, resulting in a full-scale output swing of $\pm 0.95$ volts for a $\pm 50 \mathrm{~g}$ applied acceleration. Its zero $g$ output level is +1.8 volts.
A TTL compatible self-test function can electrostatically deflect the sensor beam at any time to verify device functionality.

For convenience, the ADXL50 has an internal buffer amplifier with a full 0.25 V to 4.75 V output range. This may be used to set the zero-g level and change the output sensitivity by using external resistors. External capacitors may be added to the resistor network to provide 1 or 2 poles of filtering. No external active components are required to interface directly to most analog-to-digital converters (ADCs) or microcontrollers.
The ADXL50 uses a capacitive measurement method. The ana$\log$ output voltage is directly proportional to acceleration, and is fully scaled, referenced and temperature compensated, resulting in high accuracy and linearity over a wide temperature range. Internal circuitry implements a forced-balance control loop that improves accuracy by compensating for any mechanical sensor variations.
The ADXL50 is powered from a standard +5 V supply and is robust for use in harsh industrial and automotive environments and will survive shocks of more than 2000 g unpowered.
The ADXL50 is available in a hermetic 10-pin TO-100 metal can, specified over the $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ commercial, and $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ industrial temperature ranges. Contact factory for availability of devices specified for operation over the $-40^{\circ} \mathrm{C}$ to $+105^{\circ} \mathrm{C}$ automotive and $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ military temperature ranges and for availability of 883 B devices.

ADXL50 FUNCTIONAL BLOCK DIAGRAM


[^263]
## ADX $40 \rightarrow$ PDFGHEARATDNS $\left(T_{A}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{S}}=+5 \mathrm{~V}, @\right.$ Acceleration $=0 \mathrm{~g}$, and $\mathrm{C} 1=\mathrm{C} 2=0.022 \mu \mathrm{~F}$ unless otherwise noted)

| Parameter | ADXL50J/A |  |  | ADXL50K/B/T ${ }^{\text {* }}$ |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max |  |
| $\begin{aligned} & \text { SENSITIVITY }{ }^{1} \\ & \quad+25^{\circ} \mathrm{C} \\ & {\text { Temperature } \text { Drift }^{2}}^{2} \end{aligned}$ | 16.1 | $\begin{aligned} & 19.0 \\ & \pm 0.75 / 1.0 \end{aligned}$ | 21.9 | 16.7 | $\begin{aligned} & 19.0 \\ & \pm 0.75 / 1.0 / 1.5 \end{aligned}$ | $\begin{aligned} & 21.3 \\ & \pm 1.75 / 2.0 / 2.5 \end{aligned}$ | $\begin{aligned} & \mathrm{mV} / \mathrm{g} \\ & \% \text { of RDG } \end{aligned}$ |
| $\begin{aligned} & \hline \text { ZERO g BIAS LEVEL } \\ & +25^{\circ} \mathrm{C} \\ & {\text { Temperature } \text { Drift }^{2}}^{2} \end{aligned}$ | 1.55/1.60 | $\begin{aligned} & 1.80 \\ & \pm 15 / 35 \end{aligned}$ | 2.05/2.00 | 1.60 | $\begin{aligned} & 1.80 \\ & \pm 10 / 20 / 50 \end{aligned}$ | $\begin{aligned} & 2.00 \\ & \pm 35 / 50 / 80 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{mV} \end{aligned}$ |
| VOLTAGE NOISE DENSITY ${ }^{4}$ |  | $\begin{aligned} & 125 \\ & 6.6 \end{aligned}$ | 225 |  | $\begin{aligned} & 125 \\ & 6.6 \end{aligned}$ | 225 | $\begin{aligned} & \mu \mathrm{V} / \sqrt{\overline{\mathrm{Hz}}} \\ & \mathrm{mg} / \sqrt{\mathrm{Hz}} \end{aligned}$ |
| SENSOR INPUT <br> Measurement Range ${ }^{5}$ Nonlinearity ${ }^{6}$ Alignment Error ${ }^{7}$ Transverse Sensitivity ${ }^{8}$ | -50 | $\begin{aligned} & 0.2 \\ & \pm 1 \\ & \pm 2 \end{aligned}$ | +50 | -50 | $\begin{aligned} & 0.2 \\ & \pm 1 \\ & \pm 2 \end{aligned}$ | +50 | $\stackrel{\mathrm{g}}{\%}$ of FS <br> Degrees <br> \% |

## NOTES

${ }^{1}$ As measured at the preamplifier output, $\mathrm{V}_{\mathrm{PR}}$ with $15 \mathrm{~g} \mathrm{p}-\mathrm{p}$ @ 100 Hz applied.
${ }^{2}$ Specification refers to the maximum change in parameter from its initial value at $+25^{\circ} \mathrm{C}$ to its worst case value at $\mathrm{T}_{\text {min }}$ or $\mathrm{T}_{\text {max }}$.
${ }^{3}$ As measured at $\mathrm{V}_{\mathrm{PR}}$.
${ }^{4} \mathrm{BW}=10 \mathrm{~Hz}$ to 1 kHz . A capacitor, C 2 , greater than or equal to $0.022 \mu \mathrm{~F}$, must be connected from the oscillator decoupling capacitor pin to ground.
${ }^{5}$ The axis of sensitivity of the device is a straight line drawn through the package along its most sensitive axis. For the 10 -pin header (TO-100) package, this line passes through Pin 5 and the tab. See device connection and orientation figures.
${ }^{6}$ Best Fit Straight Line. Full scale $=50 \mathrm{~g}$.
${ }^{7}$ Alignment error is specified as the angle between the true and indicated axis of sensitivity. The ADXL50 output will be the true acceleration times the cosine of the alignment error angle.
${ }^{8}$ Transverse sensitivity is measured with an applied acceleration which is $90^{\circ}$ (i.e., transverse) from the indicated axis of sensitivity. Transverse sensitivity error is specified as the percent of transverse acceleration which appears at the $\mathrm{V}_{\mathrm{PR}}$ output. This is the algebraic sum of the alignment and the inherent sensor sensitivity errors.
Specifications subject to change without notice.

## *Contact factory for availability. <br> ELECTRICAL CHARACTERISTICS $\begin{aligned} & \left(\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {min }} \text { to } \mathrm{T}_{\text {max }}, \mathrm{V}_{\mathrm{S}}=\right. \\ & \text { unless otherwise noted })\end{aligned}$

| Parameter | Conditions | ADXL50J/A/K/B/T |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max |  |
| PREAMPLIFIER OUTPUT <br> Power Supply Rejection <br> Voltage Swing <br> Current Output Capacitive Load Drive Capability | $\begin{aligned} & \mathrm{DC} \\ & +25^{\circ} \mathrm{C} \end{aligned}$ <br> Source or Sink | $\begin{aligned} & 30 \\ & 0.25 \\ & 30 \end{aligned}$ | $\begin{aligned} & 40 \\ & 80 \\ & 100 \end{aligned}$ | $\mathrm{V}_{\mathrm{s}}-1.4$ | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~V} \\ & \mu \mathrm{~A} \\ & \mathrm{pF} \end{aligned}$ |
| SELF TEST INPUT <br> Output Change at VPR ${ }^{9}$ <br> Logic " 1 " Voltage Logic "0" Voltage Input Impedance | ST Pin from Logic "0" to " 1 " <br> To Common | $\begin{aligned} & -0.90 \\ & 2.0 \end{aligned}$ | $\begin{aligned} & -1.00 \\ & 50 \end{aligned}$ | $\begin{aligned} & -1.10 \\ & 0.8 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{k} \Omega \end{aligned}$ |
| FREQUENCY RESPONSE <br> 3 dB Equation Bandwidth ${ }^{10}$ <br> Sensor Resonant Frequency | $\begin{aligned} & \mathrm{Cl}>=0.015 \mu \mathrm{~F} \\ & \mathrm{f}_{3 \mathrm{BB}}=(28.60 / \mathrm{C} 1 \text { in } \mu \mathrm{F}) \pm 40 \% \\ & \mathrm{Cl}=0.022 \mu \mathrm{~F}(\text { See Figure } 22) \\ & \mathrm{Cl}=0.007 \mu \mathrm{~F} \end{aligned}$ | 800 | $\begin{aligned} & 1300 \\ & 10 \\ & 24 \end{aligned}$ | 2250 | Hz <br> Hz <br> kHz <br> kHz |
| +3.4 VOLT REFERENCE <br> Output Voltage Initial Output Temperature Drift ${ }^{11}$ Power Supply Rejection Output Current | $+25^{\circ} \mathrm{C}$ <br> DC <br> (Sourcing) | $\begin{aligned} & 3.350 \\ & 40 \\ & 500 \end{aligned}$ | $\begin{aligned} & 3.400 \\ & \pm 10 \\ & 60 \end{aligned}$ | 3.450 | $\begin{aligned} & \mathrm{V} \\ & \mathrm{mV} \\ & \mathrm{~dB} \\ & \mu \mathrm{~A} \end{aligned}$ |
| BUFFER AMPLIFIER <br> Input Offset Voltage ${ }^{12}$ <br> Input Bias Current <br> Open Loop Gain Unity Gain Bandwidth Output Voltage Swing Capacitive Load Drive Capability Power Supply Rejection | Deviation from Nominal 1.800 V <br> DC $\mathrm{I}_{\mathrm{OUT}}= \pm 100 \mu \mathrm{~A}$ <br> DC | $\begin{aligned} & 0.25 \\ & 1000 \\ & 40 \end{aligned}$ | $\begin{aligned} & \pm 10 \\ & 5 \\ & 80 \\ & 200 \\ & \\ & 60 \end{aligned}$ | $\begin{aligned} & \pm 25 \\ & 20 \\ & \mathrm{~V}_{\mathrm{s}}-0.25 \end{aligned}$ | mV nA dB kHz V pF dB |
| POWER SUPPLY <br> Specified Performance Operating Voltage Range Quiescent Supply Current |  | $\begin{aligned} & +4.75 \\ & +4.75 \end{aligned}$ | $\begin{aligned} & +5.00 \\ & 10 \end{aligned}$ | $\begin{aligned} & +5.25 \\ & +6.0 \\ & 13 \end{aligned}$ | V V mA |


|  |  |  | ADXL50J/A/K/B/T |  |
| :--- | :---: | :---: | :---: | :---: |
| Parameter | Conditions | Min | Typ |  |
| TEMPERATURE RANGE |  |  |  |  |
| Specified Performance J, K |  | 0 |  |  |
| Specified Performance A, B | -40 | +70 |  |  |
| Specified Performance T | -55 | +85 | +125 |  |
| Automotive Grade |  | -40 | ${ }^{\circ} \mathrm{C}$ |  |

## NOTES

${ }^{9}$ Applying logic "high" to the self-test input has an effect on the acceleration sensing element equivalent to applying an acceleration of minus 52.6 g to the ADXL50.
${ }^{10}$ This is the deviation from the ideal 3 dB bandwidth using an exact Cl value.
${ }^{11}$ Specification refers to the maximum change in parameter from its initial value at $+25^{\circ} \mathrm{C}$ to its worst case value at $\mathrm{T}_{\text {MIN }}$ or $\mathrm{T}_{\text {MAX }}$.
${ }^{12}$ Input offset voltage is defined as an output voltage (referred to input at buffer $-\mathrm{V}_{\mathrm{IN}}$ terminal) when the buffer amplifier is connected as a follower. The voltage at this pin has a temperature drift proportional to that of the +3.4 V reference.
*Contact factory for availability.
Specifications subject to change without notice.
All min and max specifications are guaranteed. Typical specifications are not tested or guaranteed.

## ABSOLUTE MAXIMUM RATINGS*ぇ

Acceleration (Any Axis, Unpowered for 0.5 ms ) . . . . . 2000 g Acceleration (Any Axis, Powered for 0.5 ms ) . . . . . . . 500 g
 Output Short Circuit Duration
( $\mathrm{V}_{\mathrm{PR}}, \mathrm{V}_{\mathrm{OUT}}, \mathrm{V}_{\text {REF }}$ Terminals to Common) . . . . . Indefinite Operating Temperature . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
**Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only; the functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## Package Characteristics

| Package | $\boldsymbol{\theta}_{\text {JA }}$ | $\boldsymbol{\theta}_{\mathrm{JC}}$ | Device Weight |  |
| :---: | :---: | :---: | :---: | :---: |
| 10-Pin TO-100 | $130^{\circ} \mathrm{C} / \mathrm{W}$ | $30^{\circ} \mathrm{C} / \mathrm{W}$ | 5 Grams |  |
| ORDERING GUIDE |  |  |  |  |
| Model | Temperature Range | Typ 0 g Bias Drift | Max 0 g Bias Drift | Package Option ${ }^{1}$ |
| ADXL50JH | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\pm 15 \mathrm{mV}$ |  | H-10A |
| ADXL50 $\mathrm{KH}^{2}$ | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\pm 10 \mathrm{mV}$ | $\pm 35 \mathrm{mV}$ | H-10A |
| ADXL50AH | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 35 \mathrm{mV}$ |  | H-10A |
| ADXL50BH ${ }^{2}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\pm 20 \mathrm{mV}$ | $\pm 50 \mathrm{mV}$ | H-10A |
| ADXL50TH ${ }^{2}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\pm 50 \mathrm{mV}$ | $\pm 80 \mathrm{mV}$ | H-10A |

NOTES
${ }^{1}$ For outline information see Package Information section.
${ }^{2}$ Contact factory for availability.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the ADXL50 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


## ADXL50 PIN DESCRIPTION

| $+5 \mathrm{~V}$ | The power supply input pin. |
| :---: | :---: |
| C2 | Connection for an external bypass capacitor (nominally $0.022 \mu \mathrm{~F}$ ) used to prevent oscillator switching noise from interfering with other ADXL50 circuitry. Please see the section on component selection. |
| C1 | Connections for the demodulator capacitor, nominally $0.022 \mu \mathrm{~F}$. See the section on component selection for application information. |
| COM | The power supply common (or "ground") connection. |
| $\mathrm{V}_{\text {REF }}$ | Output of the internal 3.4 V voltage reference. |
| ST | The digital self-test input. It is both CMOS and TTL compatible. |
| $\mathrm{V}_{\mathrm{PR}}$ | The ADXL50 preamplifier output providing an output voltage of 19 mV per g of acceleration. |
| $\mathrm{V}_{\text {Out }}$ | Output of the uncommitted buffer amplifier. |
| $\mathrm{V}_{\mathrm{IN}-}$ | The inverting input of the uncommitted buffer amplifier. |

## ADXL50 10-HEADER (TO-100) CONNECTION DIAGRAM



NOTES:
AXIS OF SENSITIVITY IS ALONG A LINE BETWEEN PIN 5 AND THE TAB.
THE CASE OF THE METAL CAN PACKAGE IS CONNECTED TO PIN 5 (COMMON).
ARROW INDICATES DIRECTION
OF POSITIVE ACCELERATION ALONG AXIS OF SENSITIVITY.


Figure 1. Output Polarity at $V_{P R}$


Figure 2a. Sensitive $X$ and Transverse $Z$ Axis


Figure 2b. Sensitive $X$ and Transverse $Y$ Axis


Figure 2c. A Vector Analysis of an Acceleration Acting Upon the ADXL50 in Three Dimensions

## Polarity of the Acceleration Output

The polarity of the ADXL50 output is shown in the Figure 1. When oriented to the earth's gravity (and held in place), the ADXL50 will experience an acceleration of +1 g . This corresponds to a change of approximately +19 mV at the $\mathrm{V}_{\mathrm{PR}}$ output pin. Note that the polarity will be reversed to a negative going signal at the buffer amplifier output $\mathrm{V}_{\text {OUT }}$, due to its inverting configuration.

## Mounting Considerations

There are three main causes of measurement error when using accelerometers. The first two are alignment and transverse sensitivity errors. The third source of error is due to resonances or vibrations of the sensor in its mounting fixture.

## Errors Due to Misalignment

The ADXL50 is a sensor designed to measure accelerations that result from an applied force. Because these forces act on the sensor in a vector manner, the alignment of the sensor to the force to be measured may be critical.
The ADXL50 responds to the component of acceleration on its sensitive $X$ axis. Figures $2 a$ and $2 b$ show the relationship between the sensitive " X " axis and the transverse " $Z$ " and " Y " axes as they relate to the TO-100 package.
Figure 2c describes a three dimensional acceleration vector ( $\mathrm{A}_{\mathrm{XYZ}}$ ) which might act on the sensor, where $\mathrm{A}_{\mathrm{X}}$ is the component of interest. To determine $A_{X}$, first, the component of acceleration in the $X Y$ plane $\left(A_{X Y}\right)$ is found using the cosine law:

$$
\begin{aligned}
A_{X Y} & =A_{X Y Z}\left(\cos \theta_{X Y}\right) \text { then } \\
& A_{X}=A_{X Y}\left(\cos \theta_{X}\right)
\end{aligned}
$$

Therefore: Typical $V_{P R}=19 \mathrm{mV} / \mathrm{g}\left(A_{X Y Z}\right)\left(\cos \theta_{X Y}\right) \cos \theta_{X}$.
Note that an ideal sensor will react to forces along or at angles to its sensitive axis but will reject signals from its various transverse axes, i.e., those exactly $90^{\circ}$ from the sensitive " X " axis. But even an ideal sensor will produce output signals if the transverse signals are not exactly $90^{\circ}$ to the sensitive axis. An acceleration that is acting on the sensor from a direction different from the sensitive axis will show up at the ADXL50 output at a reduced amplitude.

## Table I. Ideal Output Signals for Off Axis Applied Accelerations Disregarding Device Alignment and Transverse Sensitivity Errors

| $\boldsymbol{\theta}_{\mathbf{X}}$ | \% of Signal Appearing <br> at Output | Output in g's for a 50 $\mathbf{g}$ <br> Applied Acceleration |
| :--- | :--- | :--- |
| 0 | $100 \%$ | 50 (On Axis) |
| $1^{\circ}$ | $99.98 \%$ | 49.99 |
| $2^{\circ}$ | $99.94 \%$ | 49.97 |
| $3^{\circ}$ | $99.86 \%$ | 49.93 |
| $5^{\circ}$ | $99.62 \%$ | 49.81 |
| $10^{\circ}$ | $98.48 \%$ | 49.24 |
| $30^{\circ}$ | $86.60 \%$ | 43.30 |
| $45^{\circ}$ | $70.71 \%$ | 35.36 |
| $60^{\circ}$ | $50.00 \%$ | 25.00 |
| $80^{\circ}$ | $17.36 \%$ | 8.68 |
| $85^{\circ}$ | $8.72 \%$ | 4.36 |
| $87^{\circ}$ | $5.25 \%$ | 2.63 |
| $88^{\circ}$ | $3.49 \%$ | 1.75 |
| $89^{\circ}$ | $1.7 \%$ | 0.85 |
| $90^{\circ}$ | $0 \%$ | 0.00 (Transverse Axis) |

Table I shows the percentage signals resulting from various $\theta_{\mathrm{x}}$ angles. Note that small errors in alignment have a negligible effect on the output signal. A $1^{\circ}$ error will only cause a $0.02 \%$ error in the signal. Note, however, that a signal coming $1^{\circ}$ off of the transverse axis (i.e., $89^{\circ}$ off the sensitive axis) will still contribute $1.7 \%$ of its signal to the output. Thus large transverse signals could cause output signals as large as the signals of interest.
Table I may also be used to approximate the effect of the ADXL50's internal errors due to misalignment of the die to the package. For example: a 1 degree sensor alignment error will allow $1.7 \%$ of a transverse signal to appear at the output. In a nonideal sensor, transverse sensitivity may also occur due to inherent sensor properties. That is, if the sensor physically moves due to a force applied exactly $90^{\circ}$ to its sensitive axis, then this might be detected as an output signal, whereas an ideal sensor would reject such signals. In every day use, alignment errors may cause a small output peak with accelerations applied close to the sensitive axis but the largest errors are normally due to large accelerations applied close to the transverse axis.

## Errors Due to Mounting Fixture Resonances

A common source of error in acceleration sensing is resonance of the mounting fixture. For example, the circuit board that the ADXL50 mounts to may have resonant frequencies in the same range as the signals of interest. This could cause the signals measured to be larger than they really are. A common solution to this problem is to dampen these resonances by mounting the ADXL50 near a mounting post or by adding extra screws to hold the board more securely in place.
When testing the accelerometer in your end application, it is recommended that you test the application at a variety of frequencies in order to ensure that no major resonance problems exist.

## GLOSSARY OF TERMS

Acceleration: Change in velocity per unit time.
Acceleration Vector: Vector describing the net acceleration acting upon the ADXL50 ( $\mathrm{A}_{\mathrm{XYZ}}$ ).
g: A unit of acceleration equal to the average force of gravity occurring at the earth's surface. Ag is approximately equal to 32.17 feet $/ \mathrm{s}^{2}$, or 9.807 meters $/ \mathrm{s}^{2}$.

Nonlinearity: The maximum deviation of the ADXL50 output voltage from a best fit straight line fitted to a plot of acceleration vs. output voltage, calculated as a \% of the full-scale output voltage (@ 50 g ).
Resonant Frequency: The natural frequency of vibration of the ADXL50 sensor's central plate (or "beam"). At its resonant frequency of 24 kHz , the ADXL50's moving center plate has a peak in its frequency response with a Q of 3 or 4 .

Sensitivity: The output voltage change per $g$ unit of acceleration applied, specified at the $\mathrm{V}_{\mathrm{PR}}$ pin in $\mathrm{mV} / \mathrm{g}$.
Sensitive Axis (X) The most sensitive axis of the accelerometer sensor. Defined by a line drawn between the package tab and Pin 5 in the plane of the pin circle. See Figures 2a and 2b.
Sensor Alignment Error: Misalignment between the ADXL50's on-chip sensor and the package axis, defined by Pin 5 and the package tab.
Total Alignment Error: Net misalignment of the ADXL50's on-chip sensor and the measurement axis of the application. This error includes errors due to sensor die alignment to the package, and any misalignment due to installation of the sensor package in a circuit board or module.
Transverse Acceleration: Any acceleration applied $90^{\circ}$ to the axis of sensitivity.

Transverse Sensitivity Error: The percent of a transverse acceleration that appears at the $\mathrm{V}_{\mathrm{PR}}$ output. For example, if the transverse sensitivity is $1 \%$, then $\mathrm{a}+10 \mathrm{~g}$ transverse acceleration will cause a 0.1 g signal to appear at $\mathrm{V}_{\mathrm{PR}}(1 \%$ of 10 g$)$. Transverse sensitivity can result from a sensitivity of the sensor to transverse forces or from misalignment of the internal sensor to its package.
Transverse Y Axis: The axis perpendicular $\left(90^{\circ}\right)$ to the package axis of sensitivity in the plane of the package pin circle. See Figure 2.

Transverse Z Axis: The axis perpendicular ( $90^{\circ}$ ) to both the package axis of sensitivity and the plane of the package pin circle. See Figure 2.


Figure 3. 500 g Shock Overload Recovery. Top Trace: ADXL50 Output. Bottom Trace: Reference Accelerometer Output

## ADXL50-Typical Characteristics



Figure 4. Normalized Sensitivity vs. Frequency


Figure 5. Linearity in Percent of Full Scale


Figure 6. $-3 d B$ Bandwidth vs. Temperature at $V_{P R}$


Figure 7. RMS Noise vs. Value of Demodulator Capacitor, C1


Figure 8. Buffer Amplifier Output Impedance vs. Frequency


Figure 9. Buffer Amplifier Closed-Loop Gain vs. Frequency


Figure 10. Change in Sensitivity vs. Supply Voltage


Figure 11. $V_{P R} 0 g$ PSRR vs. Frequency


Figure 12. 0 g Bias Level vs. Temperature


Figure 13. Percent Change In Sensitivity at $V_{P R}$ vs. Temperature


Figure 14. +3.4 V REF PSRR vs. Frequency


Figure 15. $V_{\text {REF }}$ Output and Change in Self-Test Output Swing vs. Temperature

## ADXL50

## THEORY OF OPERATION

The ADXL50 is a complete acceleration measurement system on a single monolithic IC. It contains a polysilicon surface-micro machined sensor and signal conditioning circuitry. The ADXL50 is capable of measuring both positive and negative acceleration to a maximum level of $\pm 50 \mathrm{~g}$.
Figure 16 is a simplified view of the ADXL50's acceleration sensor at rest. The actual structure of the sensor consists of 42 unit cells and a common beam. The differential capacitor sensor consists of independent fixed plates and a movable "floating" central plate which deflects in response to changes in relative motion. The two capacitors are series connected, forming a capacitive divider with a common movable central plate. A force balance technique counters any impeding deflection due to acceleration and servos the sensor back to its 0 g position.


Figure 16. A Simplified Diagram of the ADXL50 Sensor at Rest

Figure 17 shows the sensor responding to an applied acceleration. When this occurs, the common central plate or "beam" moves closer to one of the fixed plates while moving further from the other. The sensor's fixed capacitor plates are driven deferentially by a 1 MHz square wave: the two square wave amplitudes are equal but are $180^{\circ}$ out of phase from one another. When at rest, the values of the two capacitors are the same and therefore, the voltage output at their electrical center (i.e., at the center plate) is zero.

When the sensor begins to move, a mismatch in the value of their capacitance is created producing an output signal at the central plate. The output amplitude will increase with the amount of acceleration experienced by the sensor. Information concerning the direction of beam motion is contained in the phase of the signal with synchronous demodulation being used to extract this information. Note that the sensor needs to be positioned so that the measured acceleration is along its sensitive axis.

Figure 18 shows a block diagram of the ADXL50. The voltage output from the central plate of the sensor is buffered and then applied to a synchronous demodulator. The demodulator is also supplied with a (nominal) 1 MHz clock signal from the same oscillator which drives the fixed plates of the sensor. The
demodulator will rectify any voltage which is in sync with its clock signal. If the applied voltage is in sync and in phase with the clock, a positive output will result. If the applied voltage is in sync but $180^{\circ}$ out of phase with the clock, then the demodulator's output will be negative. All other signals will be rejected. An external capacitor, Cl , sets the bandwidth of the demodulator.
The output of the synchronous demodulator drives the preamp -an instrumentation amplifier buffer which is referenced to +1.8 volts. The output of the preamp is fed back to the sensor through a $3 \mathrm{M} \Omega$ isolation resistor. The correction voltage required to hold the sensor's center plate in the 0 g position is a direct measure of the applied acceleration and appears at the $\mathrm{V}_{\mathrm{PR}}$ pin.


Figure 17. The ADXL50 Sensor Momentarily Responding to an Externally Applied Acceleration

When the ADXL50 is subjected to an acceleration, its capacitive sensor begins to move creating a momentary output signal. This is signal conditioned and amplified by the demodulator and preamp circuits. The dc voltage appearing at the preamp output is then fed back to the sensor and electrostatically forces the center plate back to its original center position.
At 0 g the ADXL50 is calibrated to provide +1.8 volts at the $\mathrm{V}_{\mathrm{PR}}$ pin. With an applied acceleration, the $\mathrm{V}_{\mathrm{PR}}$ voltage changes to the voltage required to hold the sensor stationary for the duration of the acceleration and provides an output which varies directly with applied acceleration.

The loop bandwidth corresponds to the time required to apply feedback to the sensor and is set by external capacitor C 1 . The loop response is fast enough to follow changes in $g$ level up to and exceeding 1 kHz . The ADXL50's ability to maintain a flat response over this bandwidth keeps the sensor virtually motionless. This essentially eliminates any nonlinearity or aging effects due to the sensor beam's mechanical spring constant, as compared to an open-loop sensor.
An uncommitted buffer amplifier provides the capability to adjust the scale factor and 0 g offset level over a wide range. An internal reference supplies the necessary regulated voltages for powering the chip and +3.4 volts for external use.


Figure 18. ADXL50 Functional Block Diagram

The sensor's tight mechanical spacing allows it to be electrostatically deflected to full scale while operating on a 5 volt supply. A self-test is initiated by applying a TTL "high" level voltage $(>+2.0 \mathrm{~V})$ to the ADXL50's self-test pin which causes the chip to apply a deflection voltage to the beam which moves it an amount equal to -50 g (the negative full-scale output of the device). Note that the $\pm 10 \%$ tolerance of the self-test circuit is not proportional to the sensitivity error, see Self-Test section.
The output of the ADXL50's preamplifier is 1.8 V at 0 g acceleration with an output range of $\pm 0.95 \mathrm{~V}$ for a $\pm 50 \mathrm{~g}$ input, i.e., $19 \mathrm{mV} / \mathrm{g}$. An uncommitted buffer amplifier has been included on-chip to enhance the user's ability to offset the 0 g signal level and to amplify and filter the signal. Access is provided to both
the inverting input and the output of this amplifier via pins $\mathrm{V}_{\text {OUT }}$ and $\mathrm{V}_{\text {IN }}$, while the noninverting input is connected internally to a +1.8 V reference. The +1.8 V is derived from a resistor divider connected to the 3.4 V reference.

## BASIC CONNECTIONS FOR THE ADXL50

Figure 19 shows the basic connections needed for the ADXL50 to measure accelerations in the $\pm 50 \mathrm{~g}$ range with an output scale factor $40 \mathrm{mV} / \mathrm{g}$ corresponding to a 2.5 V 0 g level, a $\pm 2.0 \mathrm{~V}$ full-scale swing around 0 g and a 3 dB bandwidth of approximately 1 kHz .
In general, the designer will need to take into account the initial zero $g$ bias when designing circuits. For the ADXL50J this offset is $1.8 \mathrm{~V} \pm 250 \mathrm{mV}$. When microprocessors and software


Figure 19. ADXL50 Application Providing an Output Sensitivity of $40 \mathrm{mV} / \mathrm{g}, \mathrm{a}+2.5 \mathrm{VOg}$ Level and a Bandwidth of 1 kHz
calibration are used and there is a desire to eliminate trim potentiometers, the design should leave room at either supply rail to account for signal swing and or variations in initial zero $g$ bias.
For example, in the circuit in Figure 19, the initial zero $g$ bias of $\pm 250 \mathrm{mV}$ will be reflected to the output by the gain of the R3/R1 network, resulting in an output offset of $\pm 526 \mathrm{mV}$ worst case. The offset, combined with a full-scale signal of 50 g , $(+2.0 \mathrm{~V})$ will cause the output buffer amplifier to saturate at the supply rail.
The full $\pm 2.25 \mathrm{~V}$ output swing of the buffer amplifier can be utilized if the user is able to trim the zero-g bias to exactly 2.5 V . In applications where the full-scale range will be $\pm 25 \mathrm{~g}$ or less, a bias trim such as that shown in Figure 20 will almost always be required.

## VARYING THE OUTPUT SENSITIVITY AND 0 g LEVEL USING THE INTERNAL BUFFER AMPLIFIER

The uncommitted buffer amplifier may be used to change the output sensitivity to provide useful full-scale ranges of $\pm 50 \mathrm{~g}$ and below. Table II provides recommended resistor values for several standard ranges down to $\pm 10 \mathrm{~g}$. As the full-scale range is decreased, buffer amplifier gain is increased, and the noise contribution as a percentage of full scale will also increase. For all ranges, the signal-to-noise ratio can be improved by reducing the circuit bandwidth, either by increasing the demodulator capacitor, Cl , or by adding a post filter using the buffer amplifier.

Table II. Recommended Resistor Values for Setting the Circuit of Figure 20 to Several Common Full-Scale Ranges

| FS (g) | Buffer <br> Gain | SF in <br> mV/g | R1 | R3 | R2 |
| :--- | :--- | :--- | :--- | :--- | :--- |
| $\pm 50.0$ | 2.11 | 40 | 49.9 k | 105 k | 100 k |
| $\pm 40.0$ | 2.63 | 50 | 39.2 k | 103 k | 100 k |
| $\pm 30.8$ | 3.42 | 65 | 40.2 k | 137 k | 100 k |
| $\pm 26.7$ | 3.95 | 75 | 28.7 k | 113 k | 100 k |
| $\pm 20.0$ | 5.26 | 100 | 26.1 k | 137 k | 100 k |
| $\pm 10.0$ | 10.53 | 200 | 23.7 k | 249 k | 100 k |

Note that the value of resistor R1 should be selected to limit the output current flowing into $\mathrm{V}_{\mathrm{PR}}$ to less than $25 \mu \mathrm{~A}$ (to provide a safety margin). For a " J " grade device, this current is equal to:

$$
I_{P R}=\frac{\left(2.05 \mathrm{~V}-\text { The peak full-scale output voltage at } V_{P R}\right)-1.8 \mathrm{~V}}{R 1 \text { in ohms }}
$$

For a $\pm 50 \mathrm{~g}$ full-scale range, R 1 needs to be $49.9 \mathrm{k} \Omega$ or larger in value; but at the lower full-scale $g$ ranges, if the $V_{P R}$ swing is much less, then it is possible to use much lower resistance values. For this table, the circuit of Figure 20 is used, as a 0 g offset trim will be required for most applications. In all cases, it is assumed that the zero-g bias level is 2.5 V with an output span of $\pm 2 \mathrm{~V}$.
Note that for full scales below $\pm 20 \mathrm{~g}$ the self-test is unlikely to operate correctly because the $\mathrm{V}_{\mathrm{PR}}$ pull-down current is not guaranteed to be large enough to drive R 1 to the required -1.0 V swing. In these cases, the self-test command will cause $\mathrm{V}_{\text {OUt }}$ to saturate at the rail, and it will be necessary to monitor the selftest at $\mathrm{V}_{\mathrm{PR}}$. Self-test can remain operational at $\mathrm{V}_{\mathrm{PR}}$ for all g
ranges listed by keeping $\mathrm{R} 1>49.9 \mathrm{k} \Omega$, with the subsequent tradeoff that the required values for R3 will become very large. The user always has the option of adding external gain and filtering stages after the ADXL50 to make lower full-scale ranges.

## Measuring Full-Scale Accelerations Less than $\pm 5 \mathrm{~g}$

Applications, such as motion detection, and tilt sensing, have signal amplitudes in the 1 g to 2 g range. Although designed for higher full-scale ranges, the ADXL50 may be adapted for use in


Figure 20. ADXL50 Circuit Using the Buffer Amplifier to Set the Output Scaling and O, g Offset Level
low g applications; the two main design considerations are noise and 0 g offset drift ( $\mathrm{BH}, \mathrm{KH}$ grades recommended).
At its full 1 kHz bandwidth, the ADXL50 will typically exhibit 1 g p -p of noise. With $\pm 50 \mathrm{~g}$ accelerations this is generally not a problem, but at a $\pm 2 \mathrm{~g}$ full-scale level the signal-to-noise ratio will be very poor. However, reducing the bandwidth to 100 Hz or less considerably improves the $\mathrm{S} / \mathrm{N}$ ratio. Figure 25 shows the relationship between ADXL50 bandwidth and noise.
The ADXL50 exhibits offset drifts that are typically 0.02 g per ${ }^{\circ} \mathrm{C}$ but which may be as large as 0.1 g per ${ }^{\circ} \mathrm{C}$. With the buffer amplifier configured for a 2 g full scale, the ADXL50 will typically drift $1 / 2$ of its full-scale range with a $50^{\circ} \mathrm{C}$ increase in temperature.
There are several cures for offset drift. If a dc response is not required, for example in motion sensing or vibration measurement applications, consider ac coupling the acceleration signal to remove the effects of offset drift. See the section on ac coupling.
Periodically recalibrating the accelerometer's 0 g level is another option. Autozero or long term averaging can be used to remove long term drift using a microprocessor or the autozero circuit of Figure 29. Be sure to keep the buffer amplifier's full-scale output range much larger than the measurement range to allow for the 0 g level drift.

## CALCULATING COMPONENT VALUES FOR SCALE FACTOR AND 0 g SIGNAL LEVEL

The ADXL50 buffer's scale factor is set by - R3/R1 (since the amplifier is in the inverter mode).

As an example, if the desired span is $\pm 2.0 \mathrm{~V}$ for a $\pm 50 \mathrm{~g}$ input, then R3/R1 should be chosen such that

$$
\begin{equation*}
R 3 / R 1=V_{O U T} S_{p a n} / V_{P R} S_{p a n}=2.00 / 0.95=2.105 \tag{1}
\end{equation*}
$$

where $V_{P R}$ span is the output from the preamplifier and $V_{\text {OUT }}$ span is the buffer amplifier's output, giving

$$
R 3=2.105 \times R 1
$$

In noncritical applications, a resistor, R2, may simply be connected between $\mathrm{V}_{\text {IN- }}$ and common to provide an approximate 0 g offset level (see Figure 19). In this simplified configuration R 2 is found using:

$$
R 2=(1.8 V \times R 3) /\left(V_{\text {OUT }} @ 0 g-1.8 V\right)
$$

When used with a trim potentiometer, as in Figure 20, resistor R2 sets the 0 g offset range and also sets the resolution of the offset trim. A value of $100 \mathrm{k} \Omega$ is typical. Increasing R2 above this value makes trimming the offset easier, but may not provide enough trim range to set $\mathrm{V}_{\mathrm{OUT}}$ equal to +2.5 V for all devices.
To provide an output span of $\pm 2.00 \mathrm{~V}$, with a 0 g output of $+2.5 \mathrm{~V}, \mathrm{R} 1$ could be set to the standard value of $49.9 \mathrm{k} \Omega$ and from Equation 2, R3 $=105 \mathrm{k} \Omega$.
For Figure 20, the circuit transfer function is:

$$
V_{O U T}=\left(\frac{R 3}{R 1}\left(1.8 V-V_{P R}\right)\right)+\left(\frac{R 3}{R 2}\left(1.8 V-V_{X}\right)\right)+1.8 V
$$

The summing amplifier configuration allows noninteractive trimming of offset and span. Since $\mathrm{V}_{\mathrm{PR}}$ is not always exactly 1.8 V at 0 g , it will contribute to output offset. Therefore, span must be trimmed first, followed by 0 g offset adjustment.

## LOAD DRIVE CAPABILITIES OF THE $V_{P R}$ AND BUFFER OUTPUTS

The $V_{P R}$ and the buffer amplifier outputs are both capable of driving a load to voltage levels approaching that of the supply rail. However, both outputs are limited in how much current they can supply, affecting component selection.

## $\mathbf{V}_{\mathbf{P R}}$ Output

The $V_{P R}$ pin has the ability to source current up to $500 \mu \mathrm{~A}$ but only has a sinking capability of $30 \mu \mathrm{~A}$ which limits its ability to drive loads. It is recommended that the buffer amplifier be used in most applications, to avoid loading down $\mathrm{V}_{\mathrm{PR}}$. In standard $\pm 50 \mathrm{~g}$ applications, the resistor R 1 from $\mathrm{V}_{\mathrm{PR}}$ to $\mathrm{V}_{\mathrm{IN}-}$ is recommended to have a value greater than $50 \mathrm{k} \Omega$ to reduce loading effects.
Capacitive loading of the $V_{P R}$ pin should be minimized. A load capacitance between the $\mathrm{V}_{\mathrm{PR}}$ pin and common will introduce an offset of approximately 1 mV for every 10 pF of load. The $\mathrm{V}_{\mathrm{PR}}$ pin may be used to directly drive an A/D input or other source as long as these sensitivities are taken into account. It is always preferable to drive A/D converters or other sources using the buffer amplifier (or an external op amp) instead of the $V_{P R}$ pin.

## Buffer Amplifier Output

The buffer output can drive a load to within 0.25 V of either power supply rail and is capable of driving 1000 pF capacitive
loads. Note that a capacitance connected across the buffer feedback resistor for low-pass filtering does not appear as a capacitive load to the buffer. The buffer amplifier is limited to sourcing or sinking a maximum of $100 \mu \mathrm{~A}$. Component values for the resistor network should be selected to ensure that the buffer amplifier can drive the filter under worst case transient conditions.

## SELF-TEST FUNCTION

The digital self-test input is compatible with both CMOS and TTL signals. A Logic " 1 " applied to the self-test (ST) input will cause an electrostatic force to be applied to the sensor which will cause it to deflect to the approximate negative full-scale output of the device. Accordingly, a correctly functioning accelerometer will respond by initiating an approximate -1 volt output change at $\mathrm{V}_{\mathrm{PR}}$. If the ADXL50 is experiencing an acceleration when the self-test is initiated, the $\mathrm{V}_{\mathrm{PR}}$ output will equal the algebraic sum of the two inputs. The output will stay at the self-test level as long as the ST input remains high and will return to the 0 g level when the ST voltage is removed.
A self-test output that varies more than $\pm 10 \%$ from the nominal -1.0 V change indicates a defective beam or a circuit problem such as an open or shorted pin or component.
Operating the ADXL50's buffer amplifier at Gains $>2$, to provide full-scale outputs of less than $\pm 50 \mathrm{~g}$, may cause the self-test output to overdrive the buffer into saturation. The self-test may still be used in the case, but the change in the output must then be monitored at the $\mathrm{V}_{\mathrm{PR}}$ pin instead of the buffer output.
Note that the value of the self-test delta is not an exact indication of the sensitivity ( $\mathrm{mV} / \mathrm{g}$ ) of the ADXL50 and, therefore, may not be used to calibrate the device for sensitivity error.
In critical applications, it may be desirable to monitor shifts in the zero-g bias voltage from its initial value. A shift in the 0 g bias level may indicate that the 0 g level has shifted which may warrant an alarm.

## POWER SUPPLY DECOUPLING

The ADXL50 power supply should be decoupled with a $0.1 \mu \mathrm{~F}$ ceramic capacitor from +5 V pin of the ADXL50 to common using very short component leads. For other decoupling considerations, see EMI/RFI section.

## OSCILLATOR DECOUPLING CAPACITOR, C2

An oscillator decoupling capacitor, C 2 , is used to remove 1 MHz switching transients in the sensor excitation signal, and is required for proper operation of the ADXL50. A ceramic capacitor with a minimum value of $0.022 \mu \mathrm{~F}$ is recommended from the oscillator decoupling capacitor pin to common. Small amounts of capacitor leakage due to a dc resistance greater than $1 \mathrm{M} \Omega$ will not affect operation (i.e., a high quality capacitor is not needed here). As with the power supply bypass capacitor, very short component leads are recommended. Although $0.022 \mu \mathrm{~F}$ is a good typical value, it may be increased for reasons of convenience, but doing this will not improve the noise performance of the ADXL50.

## ADXL50

## DEMODULATOR CAPACITOR, C1

The demodulator capacitor is connected across Pins 2 and 3 to filter the demodulated signal from the sensor beam and to set the bandwidth of the force balance control loop. This capacitor may be used to approximately set the bandwidth of the accelerometer. A capacitor is always required for proper operation.
The frequency response of the ADXL50 exhibits a single pole roll-off response whose nominal 3 dB frequency is set by the following equation:

$$
f_{3 d B}=(28.60 / C 1 \text { in } \mu F) \pm 40 \%
$$

A nominal value of $0.022 \mu \mathrm{~F}$ is recommended for C 1 . In general, the design bandwidth should be set $40 \%$ higher than the minimum desired system bandwidth due to the $\pm 40 \%$ tolerance.
A minimum value of $0.015 \mu \mathrm{~F}$ is required, (over temperature and system life), to prevent device instability or oscillation. The demodulation capacitor should be a low leakage, low drift ceramic type with an NPO (best) or X7R (good) dielectric.
In general, it's best to use the recommended $0.022 \mu \mathrm{~F}$ capacitor across the demodulator pins and perform any additional lowpass filtering using the buffer amplifier. Using a large denominator capacitor for low-pass filtering has the disadvantage that the capacitive sensor will be slow to respond to rapid changes in acceleration and, therefore, the full shock survivability of the device could be compromised. The use of the buffer for lowpass filtering generally results in smaller capacitance values and better overall performance. It is also a convenient and more precise way to set the system bandwidth. Post filtering allows bandwidth to be controlled accurately by component selection and avoids the $\pm 40 \%$ demodulation tolerance. Note that signal noise is proportional to the square root of the bandwidth of the ADXL50 and may be a consideration in component selectionsee section on noise.

Care should be taken to reduce or eliminate any leakage paths from the demodulator capacitor pins to common or to the $+5 . \mathrm{V}$ pin. Even a small imbalance in the leakage paths from these pins will result in offset shifts in the zero-g bias level. As an example, an unbalanced parasitic resistance of $30 \mathrm{M} \Omega$ from either demodulator pin to ground will result in an offset shift at $\mathrm{V}_{\mathrm{PR}}$ of approximately 50 mV . Conformal coating of PC boards with a high impedance material is recommended to avoid leakage problems due to aging or moisture.

## REDUCING THE AVERAGE POWER CONSUMPTION OF THE ADXL50

The ADXL50 is a versatile accelerometer that can be used in a wide variety of applications. In some battery powered applications, such as shipping recorders, power consumption is a critical parameter. The ADXL50 typically draws 10 mA current from a 5 V power supply which may exceed the power budgeted for the accelerometer.
For such applications, the ADXL50 can be successfully power cycled, where the power is turned on only during the period when data is sampled. Figure 21 illustrates the power-on settling of the ADXL50 during cycling where the output amplifier has a gain of one with no filtering. The settling time-constant is approximately 0.12 ms , waiting 1 ms before sampling ensures maximally accurate readings.

For example, to reduce the average power to 5 mW from its typical 50 mW , the power should be on $10 \%$ of the time. With the power on for 1 ms and off for 9 ms , a maximum sample rate of 100 Hz is achievable. Further reduction in average power can be realized with lower sample rates.


Figure 21. Power-On Settling Time when Power Cycling

## SYSTEM BANDWIDTH CONTROL AND POST FILTERING

Unlike piezoresistive sensors, the resonant frequency of the ADXL50's capacitive sensor element is typically greater than 20 kHz and does not limit the useful bandwidth of the device. Usually, the resonant frequency of the beam appears as a peak in the bandwidth response at approximately 24 kHz with a Q of 3 to 4, as shown in Figure 22.
When using the recommended $0.022 \mu \mathrm{~F}$ demodulator capacitor, be advised that the nominal 1300 Hz pole it establishes within the device can vary $\pm 40 \%$. Therefore, if additional low-pass filtering is used-at frequencies much above 600 Hz -the two poles may interact and result in a net circuit bandwidth that is lower than expected.


Figure 22. Frequency Response of the ADXL50 for Various Demodulator Capacitors

RECOMMENDED COMPONENT VALUES FOR VARIOUS
FULL SCALE RANGES AND A 300 Hz BANDWIDTH

| FULL <br> SCALE | mV <br> per g | 3dB <br> $\mathrm{BW}(\mathrm{Hz})$ | R1a <br> $\mathrm{k} \Omega$ | R1b <br> $\mathrm{k} \Omega$ | R3 <br> $\mathrm{k} \Omega$ | R2 <br> $\mathrm{k} \Omega$ | $\mathrm{C4}$ <br> $\mu \mathrm{~F}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\pm \mathbf{1 0 \mathrm { g }}$ | 200 | 300 | 5 | 21.5 | 249 | 100 | 0.0022 |
| $\pm \mathbf{2 0} \mathrm{g}$ | 100 | 300 | 5 | 23.7 | 137 | 100 | 0.0039 |
| $\pm \mathbf{4 0} \mathrm{g}$ | 50 | 300 | 10 | 34 | 105 | 100 | 0.0056 |
| $\pm 50 \mathrm{~g}$ | 40 | 300 | 10 | 45.3 | 105 | 100 | 0.0056 |

$3 \mathrm{~dB} \mathrm{BW}=\frac{1}{2 \pi \mathrm{R}^{\mathrm{C}} \mathbf{C 4}}$


Figure 23. Using the Buffer Amplifier to Provide One Pole Post Filtering Plus Scale Factor and 0 g Level Trimming

## ONE POLE POST FILTERING

Figure 23 shows the ADXL50 buffer amplifier connected to provide one pole post filtering, 0 g offset trimming, and output scaling. The table included with the figure lists practical component values for various full-scale $g$ levels and approximate circuit bandwidths. For bandwidths other than those listed, use the formula:

$$
\begin{aligned}
& \text { Capacitor C4 in Farads }=1 /(2 \pi \times R 3 \text { in Ohms } \\
& \times 3 d B B W \text { in Hertz })
\end{aligned}
$$

or simply scale the value of capacitor C 4 accordingly; i.e., for a $\pm 20 \mathrm{~g}$ application with a 50 Hz bandwidth, the value of C 4 will
need to be twice as large as its 100 Hz value or $0.012 \mu \mathrm{~F} \times 2=$ $0.024 \mu \mathrm{~F}$. The closest standard value of $0.022 \mu \mathrm{~F}$ should then be used.

## TWO POLE POST FILTERING

Figure 24 shows a circuit which uses the ADXL50's buffer amplifier to provide two pole post filtering. An AD820 external op amp allows noninteractive adjustment of 0 g offset and scale factor. Component values for the two pole filter were selected to operate the buffer at unity gain with a Q of one.


Figure 24. Circuit Providing Two Pole Post Filtering and 0 g Offset and Scale Factor Trimming

Capacitors C3 and C4 are chosen to provide the desired 3 dB bandwidth. Component values are specified for bandwidths of $10 \mathrm{~Hz}, 30 \mathrm{~Hz}, 100 \mathrm{~Hz}$, and 300 Hz . For other 3 dB bandwidths simply scale the capacitor values; i.e., for a 3 dB bandwidth of 20 Hz , divide the 10 Hz bandwidth numbers by 2.0 . The nominal buffer amplifier output will be $+1.8 \mathrm{~V} \pm 19 \mathrm{mV} / \mathrm{g}$. Note that the ADXL50's self-test will be fully functional since the buffer amplifier is operated at unity gain and resistor R1 is large. The external op amp offsets and scales the output to provide $\mathrm{a}+2.5 \mathrm{~V} \pm 2 \mathrm{~V}$ output over a wide range of full-scale g levels. The external op amp may be omitted in high g , low gain applications.

## NOISE CONSIDERATIONS

The output noise of the ADXL50 scales with the square root of its bandwidth. The noise floor may be reduced by lowering the bandwidth of the ADXL50 either by increasing the value of the demodulator capacitor or by adding an external filter.
The typical rms noise of the ADXL50J with a bandwidth of 100 Hz and a noise density of $125 \mu \mathrm{~V} / \sqrt{\mathrm{Hz}}$ is estimated as follows:

$$
\text { Noise }(r m s)=(125 \mu V / \sqrt{H z}) \sqrt{100}=1.25 \mathrm{mV} \mathrm{rms}
$$

Peak-to-peak noise may be estimated with the following equation:

$$
\text { Noise } p-p=(6.6) \text { Noise rms }
$$

Peak-to-peak noise is thus estimated at 8.25 mV or approximately $0.4 \mathrm{~g} \mathrm{p-p} .\mathrm{The} \mathrm{ADXL50} \mathrm{noise} \mathrm{is} \mathrm{characteristic} \mathrm{of} \mathrm{white}$ noise. Typical rms and p-p noise for various 3 dB bandwidths is estimated in Figure 25.


Figure 25. ADXL50 Noise Level and Resolution vs. $-3 d B$ Bandwidth

Because the ADXL50's noise is for all practical purposes Gaussian in amplitude distribution, the highest noise amplitudes have the smallest (yet nonzero) probability. Peak-to-peak noise is, therefore, difficult to measure and can only be estimated due to its statistical nature. Table III is useful for estimating the probabilities of exceeding various peak values, given the rms value.

Table III.

| Nominal Peak-to- <br> Peak Value | \% of Time that Noise will Exceed <br> Nominal Peak-to-Peak Value |
| :--- | :--- |
| $2.0 \times \mathrm{rms}$ | $32 \%$ |
| $3.0 \times \mathrm{rms}$ | $13 \%$ |
| $4.0 \times \mathrm{rms}$ | $4.6 \%$ |
| $5.0 \times \mathrm{rms}$ | $1.2 \%$ |
| $6.0 \times \mathrm{rms}$ | $0.27 \%$ |
| $\mathbf{6 . 6} \times \mathrm{rms}$ | $0.1 \%$ |
| $7.0 \times \mathrm{rms}$ | $0.046 \%$ |
| $8.0 \times \mathrm{rms}$ | $0.006 \%$ |

## AC COUPLING $V_{P R}$ TO BUFFER INPUT

If a dc response is not required, as in applications such as motion detection or vibration measurement, then ac coupling should be considered. In low $g$ applications, the output voltage change due to acceleration is small compared to the 0 g offset voltage drift. Because ac coupling removes the dc component of the output, the preamp output signal may be amplified considerably without increasing the 0 g level drift. The most effective way to ac couple the ADXL50 is between the preamp output at $\mathrm{V}_{\mathrm{PR}}$ and the buffer input, $\mathrm{V}_{\mathrm{IN}-}$, as shown in Figure 26.


Figure 26. AC Coupling the $V_{P R}$ Output to the Buffer Input
Using this configuration, the system's ac response is now rolled off-at the low frequency end at $F_{L}$, and at the high frequency end at $\mathrm{F}_{\mathbf{H}}$. The normalized frequency response of the system can be seen in Figure 27.
The low frequency roll-off, $\mathrm{F}_{\mathrm{L}}$, due to the ac coupling network is:

$$
F_{L}=1 /(2 \pi R 1 C 4)
$$

The high frequency roll-off $\mathrm{F}_{\mathrm{H}}$ is determined by the dominant pole of the system which is controlled by either the demodulator capacitor and its associated time-constant or by a dominant post filter.
As a consequence of ac coupling, any constant acceleration component will not be detected (because this too is a dc voltage present at the $\mathrm{V}_{\mathrm{PR}}$ output). The self-test feature, if used, must be monitored at $\mathrm{V}_{\mathrm{PR}}$, rather than at the buffer output.


Figure 27. Normalized Output Level vs. Frequency for a Typical Application Using AC Coupling Between $V_{P R}$ and Buffer Amplifier

## MINIMIZING EMI/RFI

The architecture of the ADXL50 and its use of synchronous demodulation make the device immune to most electro-magnetic (EMI) and radio frequency (RFI) interference. The use of synchronous demodulation allows the circuit to reject all signals except those at the frequency of the oscillator driving the sensor element. However, the ADXL50 does have a sensitivity to RFI that is within $\pm 5 \mathrm{kHz}$ of the internal oscillator's nominal frequency of 1 MHz . The internal oscillator frequency will exhibit part to part variation in the range of 0.6 MHz to 1.4 MHz .
In general the effect is difficult to notice as the interference must match the internal oscillator within $\pm 5 \mathrm{kHz}$ and must be large in amplitude. For example: a 1 MHz interference signal of 20 mV p-p applied to the +5 V power supply pin will produce a 200 mV p-p signal at the $\mathrm{V}_{\mathrm{PR}}$ pin if the internal oscillator and interference signals are matched exactly. If the same 20 mV interference is applied but 5 kHz above or below the internal oscillator's frequency, the signal level at $\mathrm{V}_{\mathrm{PR}}$ will only be 20 mV $\mathrm{p}-\mathrm{p}$ in amplitude.
Power supply decoupling, short component leads (especially for capacitors Cl and C 2 ), physically small (surface mount, etc.) components and attention to good grounding practices all help to prevent RFI and EMI problems. Please consult the factory for applications assistance in instances where this may be of concern.

## SELF-CALIBRATING THE ADXL50

If a calibrated shaker is not available, both the 0 g level and scale factor of the ADXL50 may be easily set to fair accuracy by using a self-calibration technique based on the 1 g (average) acceleration of the earth's gravity. Figure 28 shows how gravity and package orientation affect the ADXL50's output (TO-100
package shown). Note that the output polarity is that which appears at $\mathrm{V}_{\mathrm{PR}}$; the output at $\mathrm{V}_{\mathrm{OUT}}$ will have the opposite sign. With its axis of sensitivity in the vertical plane, the ADXL50 should register a 1 g acceleration, either positive or negative, depending on orientation. With the axis of sensitivity in the horizontal plane, no acceleration ( 0 g ) should be indicated.

$\mathbf{0 g}$
$\mathbf{O g}$
(a)

$\mathbf{O g}$
(b)

-19
(c)

$+1 g$
(d)


Figure 28. Using the Earth's Gravity to Self-Calibrate the ADXL50

To self-calibrate the ADXL50, place the accelerometer on its side with its axis of sensitivity oriented as shown in "a." The 0 g offset potentiometer, Rt , is then roughly adjusted for midscale: +2.5 V at the buffer output. If the optional scale factor trimming is to be used, it should be adjusted next.
Next, the package axis should be oriented as in " $c$ " (pointing down) and the output reading noted. The package axis should then be rotated $180^{\circ}$ to position " d " and the scale factor potentiometer, Rla, adjusted so that the output voltage indicates a change of 2 g 's in acceleration. For example, if the circuit scale factor at the buffer output is 100 mV per g , then the scale factor trim should be adjusted so that an output change of 200 mV is indicated.
Adjusting the circuit's scale factor will have some effect on its 0 g level so this should be readjusted, as before, but this time checked in both positions "a" and "b." If there is a difference in the 0 g reading, a compromise setting should be selected so that the reading in each direction is equidistant from +2.5 V . Scale factor and 0 g offset adjustments should be repeated until both are correct. Temporarily placing a capacitor across the buffer amplifier's feedback resistor will reduce output noise and so aid in trimming the device. Note that, for high full-scale g ranges, $\pm 2 \mathrm{~g}$ may be a very small fraction of the full-scale range and device nonlinearity will, therefore, affect the circuit's high $g$ level accuracy.

Compensating for the $\mathbf{0 g}$ Drift of the ADXL50 Accelerometer The circuit of Figure 29 provides a linear temperature compensation for the ADXL50. Figure 30 shows the 0 g drift over temperature for a typical ADXL50 with and without this circuit. As shown by Figure 30, the linear portion of the drift curve has been subtracted out. In effect, the curve has been rotated counterclockwise until it is horizontal, leaving just the bow of the curve: that portion which is not linear. As shown by Figure 30 , over a $+25^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ range, a $10 \times$ reduction in drift is achieved.
The circuit of Figure 29 is essentially a temperature sensor coupled to a Whetstone bridge. The AD590 provides a $1 \mu \mathrm{~A} /{ }^{\circ} \mathrm{K}$ current output whose voltage scale factor is set by resistor RA. The bridge circuit subtracts out the nominal 298 mV output of the AD590 at $+25^{\circ} \mathrm{C}$ and leaves only the change in temperature, which is what is needed. Without the bridge, the 298 mV room temperature "offset" would "swamp" the much smaller change in output with temperature.
Resistors R5 and R6 form a resistor divider (one half of the bridge) which divides down the +3.4 V reference output of the ADXL50 to 0.3 V which appears at the noninverting input of the AD820 op amp. Resistors R7 and R8 form the other half of the bridge, and because they have the same ratio as R5 and R6, the op amp will have a +3.4 V output at room temperature.


CALIBRATION PROCEEDURE:
AT $T_{\text {MIN }}$ OR LOWER TEMP CAL POINT...

1. Set rb all the way to one side.
2. ADJUST RA FOR +3.4 V AT TEST POINT "A."
3. SET RC FOR $+2.5 \mathrm{~V} \mathrm{~V}_{\text {OUT }}$ (AT PIN 9 OF ADXL50).
4. TEMPORARILY CONNECT A $1.5 \mathrm{k} \Omega$ RESISTOR BETWEEN THE CENTER OF RB AND GROUND.
5. ADJUST RB FOR +2.5 V AT $V_{\text {OUT }}$ -
6. REMOVE THE $1.5 \mathrm{k} \Omega$ RESISTORT. $V_{\text {OUT }}$ SHOULD NOT CHANGE.
7. GO TO T MAX OR HIGH TEMP CAL POINT.
8. READJUST RB FOR +2.5 V .
9. CALIBRATION COMPLETE.

Figure 29. ADXL50 0 g Drift Compensation Circuit


Figure 30. ADXL50 0 g Drift With and Without the Compensation Circuit of Figure 29

## ADXL50 Applications Literature Available

Contact the Analog Devices Literature Center.

1. Using the ADXL50 Accelerometer in Low g Applications (AN-374) Application note covering resolution issues, bandwidth limiting, ac coupling issues, oversampling and other noise reduction techniques, gain selection issues, offset drift considerations, plus low g circuits and tables.
2. Using the ADXL50EM Accelerometer Evaluation Module (AN-376)
Application note covering mounting and resonance issues, effects of potting the module cavity, typical frequency response curves.
3. Reducing the Average Power Consumption of the ADXL50 (AN-378)
How to power cycle the ADXL50 to dramatically reduce the standby current of the device for longer battery life.
4. Mounting Considerations for the ADXL50 (AN-379)

An overview of accelerometer mounting and resonance issues.
5. Increasing the Frequency Response of the ADXL50 (AN-377)

How to extend the high frequency response of the ADXL50 by decreasing the value of compensation capacitor.
6. Compensating for the ADXL50 0 g Drift (AN-380)

Practical hardware and software corrections to compensate for the 0 g bias level drift over temperature.

Monolithic Accelerometer with Signal Conditioning

FEATURES
Complete Acceleration Measurement System on a Single Monolithic IC
Full-Scale Measurement Range: +5 V Supply: - $\mathbf{1 2 5} \mathbf{g}, \mathbf{+ 2 5 0} \mathbf{g}$ +12 V Supply: -150 g, +880 g
Self-Test on Digital Command
Single Supply Operation
Sensitivity Precalibrated to $\mathbf{8 ~ m V} / \mathrm{g}$
Internal Buffer Amplifier for User Adjustable Sensitivity and Zero-g Level
Frequency Response: DC to $\mathbf{3} \mathbf{k H z}$
Post Filtering with External Passive Components
High Shock Survival: >2000 g Unpowered
Other Products Available Providing Different Sensitivities and Full-Scale Ranges

## GENERAL DESCRIPTION

The ADXL181 is a complete acceleration measurement system on a single monolithic IC, using a surface micromachined capacitive measurement method. The analog output voltage is
directly proportional to acceleration and is fully scaled, referenced, and temperature compensated, resulting in high accuracy and linearity over a wide temperature range. Internal circuitry implements a force-balance control loop that compensates for any mechanical sensor variations.
A TTL compatible self-test feature can electrostatically deflect the sensor beam at any time to verify device functionality.
An internal buffer amplifier has a 0.25 V to $\mathrm{V}_{\mathrm{S}}-0.25 \mathrm{~V}$ output range. This may be used to gain and offset adjust the output signal so that it has a symmetrical output range. The amplifier can also be used to gain adjust and filter the sensor output.
No external active components are necessary to connect the output signal directly to an analog-to-digital converter or microcontroller.
The ADXL181 is packaged in a hermetic 10 -pin TO-100 metal can. Contact factory for availability of devices with specific temperature ranges and performance.



10-PIN TO-100 HEADER PACKAGE NOTE: AXIS OF SENSITIVITY IS IN PLANE OF PIN 5 TO TAB.
*Patent pending.

This is a preliminary data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

ADXL $181-S D E G|F| G A D N S\left(T_{A}=+25^{\circ} \mathrm{C}, \mathrm{V}_{S}=+5 \mathrm{~V}\right.$, @ Acceleration $=0 \mathrm{~g}$, and $\mathrm{C} 1=\mathrm{C} 2=0.022 \mu \mathrm{~F}$ unless otherwise noted)

| Parameter | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { SENSITIVITY } \\ & +25^{\circ} \mathrm{C} \\ & \text { Temperature Drift } \end{aligned}$ |  | 8 $\pm 0.75$ |  | $\begin{aligned} & \mathrm{mV} / \mathrm{g} \\ & \% \text { of Reading } \end{aligned}$ |
| $\begin{aligned} & \text { ZERO g BIAS LEVEL } \\ & +25^{\circ} \mathrm{C} \\ & \mathrm{~T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }} \\ & \text { Temperature Drift } \end{aligned}$ |  | 8 $\pm 75$ |  | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{mV} \end{aligned}$ |
| VOLTAGE NOISE DENSITY |  | 65 |  | $\mu \mathrm{V} / \sqrt{\mathrm{Hz}}$ |
| SENSOR INPUT <br> FS Measurement Range ${ }^{1}$ <br> Nonlinearity <br> Alignment Error Transverse Sensitivity | -125 | $\begin{aligned} & 0.2 \\ & \pm 1 \\ & \pm 2 \end{aligned}$ | +250 | $\stackrel{\mathrm{g}}{\%}$ of FS <br> Degrees <br> \% |

## NOTES

${ }^{4}$ Accelerations up to $-150 \mathrm{~g},+880 \mathrm{~g}$ using a +12 V Supply.

## Specifications subject to change without notice. <br> ELECTRICAL CHARACTERISTICS $\begin{gathered}\left(\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {miN }} \text { to } \mathrm{I}_{\text {max }}, \mathrm{V}_{\mathrm{S}}=+5\right. \\ \text { unless otherwise noted) }\end{gathered}$

| Parameter | Conditions | Min ${ }^{\text {P }}$ Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: |
| PREAMPLIFIER OUTPUT <br> Power Supply Rejection Voltage Swing Current Output Capacitive Load Drive | DC $+25^{\circ} \mathrm{C}$ <br> Source or Sink |  | V -0.25 | dB <br> V <br> $\mu \mathrm{A}$ <br> pF |
| SELF-TEST INPUT <br> Output Change at $\mathrm{V}_{\mathrm{PR}}$ ST Pin from Logic " 0 " to "l" Logic " 1 " Voltage Logic "0" Voltage Input Impedance | To Common | $\begin{array}{ll} -0.80 \\ 2.0 & -0.90 \end{array}$ $50$ | $\begin{aligned} & -1.00 \\ & 0.8 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{k} \Omega \end{aligned}$ |
| FREQUENCY RESPONSE <br> 3 dB Equation $\mathrm{C} 1>=0.015 \mu \mathrm{~F}$ Bandwidth <br> Sensor Resonant Frequency | $\begin{aligned} & \mathrm{f}=3 \mathrm{~dB}=(66 / \mathrm{C} 1 \text { in } \mu \mathrm{F}) \pm 40 \% \\ & \mathrm{C} 1=0.022 \mu \mathrm{~F} \\ & \mathrm{C} 1=\mathrm{TBD} \end{aligned}$ | $\begin{aligned} & 3000 \\ & 10,000 \\ & 24 \end{aligned}$ |  | Hz <br> Hz <br> kHz |
| +3.4 VOLT REFERENCE <br> Output Voltage Initial Output Temperature Drift Power Supply Rejection Output Current | $+25^{\circ} \mathrm{C}$ <br> DC <br> (Sourcing) | 3.350 3.400 <br>  $\pm 10$ <br> 40 60 <br> 500  | 3.450 | $\begin{aligned} & \mathrm{V} \\ & \mathrm{mV} \\ & \mathrm{~dB} \\ & \mu \mathrm{~A} \end{aligned}$ |
| BUFFER AMPLIFIER <br> Input Offset Voltage Input Bias Current Open Loop Gain Unity Gain Bandwidth Output Voltage Swing Capacitive Load Drive | Deviation from Nominal 1.800 V <br> DC $\mathrm{I}_{\text {OUT }}=100 \mu \mathrm{~A}$ |  $\pm 10$ <br>  5 <br>  80 <br>  200 <br> 0.25  <br> 1000  <br>   | $\begin{aligned} & \pm 25 \\ & 20 \\ & \mathrm{~V}_{\mathrm{S}}-0.25 \end{aligned}$ | mV <br> nA <br> dB <br> kHz <br> V <br> pF |
| POWER SUPPLY <br> Specified Performance <br> Quiescent Supply Current | 5 V Supply <br> 12 V Supply <br> 5 V Supply | $\begin{array}{ll} +4.75 & \\ +11.6 & 11 \end{array}$ | $\begin{aligned} & +5.25 \\ & +12.6 \\ & 14 \end{aligned}$ | V V mA |
| TEMPERATURE RANGE |  | -55 | +125 | ${ }^{\circ} \mathrm{C}$ |

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

ANALOG
Low Power, Programmable DEVICES

FEATURES
$-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}\left(-67^{\circ} \mathrm{F}\right.$ to $\left.+257^{\circ} \mathrm{F}\right)$ Operation $\pm 0.5^{\circ} \mathrm{C}$ Accuracy Over Temperature (typ) Temperature-Proportional Voltage Output User Programmable Temperature Trip Points
User Programmable Hysteresis 20 mA Open Collector Trip Point Outputs TTL/CMOS Compatible
Single-Supply Operation (4.5 V to 13.2 V )
Low Cost 8-Pin DIP and SO Packages

## APPLICATIONS

Over/Under Temperature Sensor and Alarm
Board Level Temperature Sensing
Temperature Controllers
Electronic Thermostats
Thermal Protection
HVAC Systems
Industrial Process Control
Remote Sensors

## GENERAL DESCRIPTION

The TMP01 is a temperature sensor which generates a voltage output proportional to absolute temperature and a control signal from one of two outputs when the device is either above or below a specific temperature range. Both the high/low temperature trip points and hysteresis (overshoot) band are determined by user-selected external resistors. For high volume production, these resistors are available on-board.

The TMP01 consists of a bandgap voltage reference combined with a pair of matched comparators. The reference provides both a constant 2.5 V output and a voltage proportional to absolute temperature (VPTAT) which has a precise temperature coefficient of $5 \mathrm{mV} / \mathrm{K}$ and is 1.49 V (nominal) at $+25^{\circ} \mathrm{C}$. The comparators compare VPTAT with the externally set temperature trip points and generate an open-collector output signal when one of their respective thresholds has been exceeded.

FUNCTIONAL BLOCK DIAGRAM


Hysteresis is also programmed by the external resistor chain and is determined by the total current drawn out of the 2.5 V reference. This current is mirrored and used to generate a hysteresis offset voltage of the appropriate polarity after a comparator has been tripped. The comparators are connected in parallel, which guarantees that there is no hysteresis overlap and eliminates erratic transitions between adjacent trip zones.
The TMP01 utilizes proprietary thin film resistors in conjunction with production laser trimming to maintain a temperature accuracy of $\pm 2^{\circ} \mathrm{C}$ (typ) over the rated temperature range, with excellent linearity. The open-collector outputs are capable of sinking 20 mA , enabling the TMP01 to drive control relays directly. Operating from a +5 V supply, quiescent current is only $500 \mu \mathrm{~A}$ (max).
The TMP01 is available in the low cost 8-pin epoxy mini-DIP and SO (small outline) packages, and in die form.

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUTS SET HIGH, SET LOW Offset Voltage Offset Voltage Drift Input Bias Current, "E" Input Bias Current, "F" | $\begin{aligned} & \mathrm{V}_{\mathrm{OS}} \\ & \mathrm{TCV}_{\mathrm{Os}} \\ & \mathrm{I}_{\mathrm{B}} \\ & \mathrm{I}_{\mathrm{B}} \end{aligned}$ |  |  | $\begin{aligned} & 0.25 \\ & 3 \\ & 25 \\ & 25 \end{aligned}$ | $\begin{aligned} & 50 \\ & 100 \end{aligned}$ | mV <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ <br> nA <br> nA |
| OUTPUT VPTAT ${ }^{1}$ <br> Output Voltage <br> Scale Factor <br> Temperature Accuracy, "E" Temperature Accuracy, "F" Temperature Accuracy, "E" Temperature Accuracy, "F" Temperature Accuracy, "E" Temperature Accuracy, "F" Temperature Accuracy, "E" Temperature Accuracy, "F" Repeatability Error Long Term Drift Error Power Supply Rejection Ratio | VPTAT TC ${ }_{\text {VPtat }}$ <br> $\triangle$ VPTAT PSRR | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, No Load <br> $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, No Load <br> $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, No Load <br> $10^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<40^{\circ} \mathrm{C}$, No Load <br> $10^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<40^{\circ} \mathrm{C}$, No Load <br> $-40^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<85^{\circ} \mathrm{C}$, No Load <br> $-40^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<85^{\circ} \mathrm{C}$, No Load <br> $-55^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<125^{\circ} \mathrm{C}$, No Load <br> $-55^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<125^{\circ} \mathrm{C}$, No Load <br> Note 4 <br> Notes 2 and 6 <br> $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, 4.5 \mathrm{~V} \leq \mathrm{V}+\leq 13.2 \mathrm{~V}$ | $\begin{aligned} & -1.5 \\ & -3 \\ & -3.0 \\ & -5.0 \end{aligned}$ | $\begin{aligned} & 1.49 \\ & 5 \\ & \pm 0.5 \\ & \pm 1.0 \\ & \pm 0.75 \\ & \pm 1.5 \\ & \pm 1 \\ & \pm 2 \\ & \pm 1.5 \\ & \pm 2.5 \\ & 0.25 \\ & 0.25 \\ & \pm 0.02 \end{aligned}$ | $\begin{aligned} & 1.5 \\ & 3 \\ & 3.0 \\ & 5.0 \\ & \\ & \\ & 0.5 \\ & \pm 0.1 \end{aligned}$ | V <br> $\mathrm{mV} / \mathrm{K}$ <br> ${ }^{\circ} \mathrm{C}$ <br> ${ }^{\circ} \mathrm{C}$ <br> ${ }^{\circ} \mathrm{C}$ <br> ${ }^{\circ} \mathrm{C}$ <br> ${ }^{\circ} \mathrm{C}$ <br> ${ }^{\circ} \mathrm{C}$ <br> ${ }^{\circ} \mathrm{C}$ <br> ${ }^{\circ} \mathrm{C}$ <br> Degree <br> Degree <br> \%/V |
| OUTPUT VREF <br> Output Voltage, "E" <br> Output Voltage, "F" <br> Output Voltage, "E" <br> Output Voltage, "F" <br> Output Voltage, "E" <br> Output Voltage, "F" <br> Drift <br> Line Regulation <br> Load Regulation <br> Output Current, Zero Hysteresis Hysteresis Current Scale Factor Turn-On Settling Time | VREF <br> VREF <br> VREF <br> VREF <br> VREF <br> VREF <br> TC ${ }_{\text {VREF }}$ <br> $I_{\text {VREF }}$ <br> $\mathrm{SF}_{\mathrm{HYS}}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, No Load <br> $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, No Load <br> $-40^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<85^{\circ} \mathrm{C}$, No Load <br> $-40^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<85^{\circ} \mathrm{C}$, No Load <br> $-55^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<125^{\circ} \mathrm{C}$, No Load <br> $-55^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<125^{\circ} \mathrm{C}$, No Load $\begin{aligned} & 4.5 \mathrm{~V} \leq \mathrm{V}+\leq 13.2 \mathrm{~V} \\ & 10 \mu \mathrm{~A} \leq \mathrm{I}_{\mathrm{VREF}} \leq 500 \mu \mathrm{~A} \end{aligned}$ <br> (Note 1) <br> To Rated Accuracy | $\begin{aligned} & 2.495 \\ & 2.490 \\ & 2.490 \\ & 2.485 \end{aligned}$ | $\begin{aligned} & 2.500 \\ & 2.500 \\ & 2.500 \\ & 2.500 \\ & 2.5 \pm 0.01 \\ & 2.5 \pm 0.015 \\ & -10 \\ & \pm 0.01 \\ & \pm 0.1 \\ & 7 \\ & 5.0 \\ & 25 \end{aligned}$ | $\begin{aligned} & 2.505 \\ & 2.510 \\ & 2.510 \\ & 2.515 \\ & \because \end{aligned}$ | V <br> V <br> V <br> V <br> V <br> V <br> $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ <br> \%/V <br> $\% / \mathrm{mA}$ <br> $\mu \mathrm{A}$ <br> $\mu \mathrm{A} /{ }^{\circ} \mathrm{C}$ <br> $\mu \mathrm{s}$ |
| OPEN-COLLECTOR OUTPUTS <br> Output Low Voltage <br> Output Low Voltage <br> Output Leakage Current Fall Time | R, UNDER <br> $\mathrm{V}_{\mathrm{OL}}$ <br> $\mathrm{V}_{\mathrm{OL}}$ <br> $\mathrm{I}_{\mathrm{OH}}$ <br> $\mathrm{t}_{\mathrm{HL}}$ | $\begin{aligned} & \mathrm{I}_{\text {SINK }}=1.6 \mathrm{~mA} \\ & \mathrm{I}_{\text {SINK }}=20 \mathrm{~mA} \\ & \mathrm{~V}+=12 \mathrm{~V} \end{aligned}$ <br> See Test Load |  | $\begin{aligned} & 0.25 \\ & 0.6 \\ & 1 \\ & 40 \end{aligned}$ | 0.4 100 | V $\mu \mathrm{A}$ ns |
| POWER SUPPLY <br> Supply Range <br> Supply Current <br> Supply Current <br> Power Dissipation | V+ <br> $\mathrm{I}_{\mathrm{SY}}$ <br> $I_{S Y}$ <br> $\mathrm{P}_{\text {DISS }}$ | Unloaded, $+\mathrm{V}=5 \mathrm{~V}$ <br> Unloaded, $+\mathrm{V}=13.2 \mathrm{~V}$ $+\mathrm{V}=5 \mathrm{~V}$ | 4.5 | $\begin{aligned} & 400 \\ & 450 \\ & 2.0 \end{aligned}$ | $\begin{aligned} & 13.2 \\ & 500 \\ & 800 \\ & 2.5 \end{aligned}$ | V <br> $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ <br> mW |

## NOTES

${ }^{1} \mathrm{~K}={ }^{\circ} \mathrm{C}+273.15$.
${ }^{2}$ Guaranteed but not tested.
${ }^{3}$ Does not consider errors caused by heating due to dissipation of output load currents.
${ }^{4}$ Maximum deviation between $+25^{\circ} \mathrm{C}$ readings after temperature cycling between $-55^{\circ} \mathrm{C}$ and $+125^{\circ} \mathrm{C}$.
${ }^{5}$ Typical values indicate performance measured at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.
${ }^{6}$ Observed in a group sample over an accelerated life test of 500 hours at $150^{\circ} \mathrm{C}$.
Specifications subject to change without notice.
Test Load


TMPO1] _SPESIFIGATIONS $\begin{gathered}\text { TO-99 Metal Can Package }\left(\mathrm{V}+=+5 \mathrm{~V}, \mathrm{GND}=0 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}\right.\end{gathered}$

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUTS SET HIGH, SET LOW <br> Offset Voltage Offset Voltage Drift Input Bias Current, " F " | $\begin{aligned} & \mathrm{V}_{\mathrm{OS}} \\ & \mathrm{TCV}_{\mathrm{Os}} \\ & \mathrm{I}_{\mathrm{B}} \end{aligned}$ |  |  | $\begin{aligned} & 0.25 \\ & 3 \\ & 25 \end{aligned}$ | 100 | mV <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ <br> nA |
| OUTPUT VPTAT ${ }^{1}$ <br> Output Voltage <br> Scale Factor <br> Temperature Accuracy, "F" <br> Temperature Accuracy, " F " <br> Temperature Accuracy, "F" <br> Temperature Accuracy, "F" <br> Repeatability Error <br> Long Term Drift Error <br> Power Supply Rejection Ratio | VPTAT TC ${ }_{\text {vptat }}$ <br> $\Delta$ VPTAT PSRR | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, No Load <br> $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, No Load <br> $10^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<40^{\circ} \mathrm{C}$, No Load <br> $-40^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<85^{\circ} \mathrm{C}$, No Load <br> $-55^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<125^{\circ} \mathrm{C}$, No Load <br> Note 4 <br> Notes 2 and 6 $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, 4.5 \mathrm{~V} \leq \mathrm{V}+\leq 13.2 \mathrm{~V}$ | $\begin{aligned} & -3 \\ & -5.0 \end{aligned}$ | $\begin{aligned} & 1.49 \\ & 5 \\ & \pm 1.0 \\ & \pm 1.5 \\ & \pm 2 \\ & \pm 2.5 \\ & 0.25 \\ & 0.25 \\ & \pm 0.02 \end{aligned}$ | $\begin{aligned} & 3 \\ & 5.0 \\ & \\ & 0.5 \\ & \pm 0.1 \end{aligned}$ | V <br> $\mathrm{mV} / \mathrm{K}$ <br> ${ }^{\circ} \mathrm{C}$ <br> ${ }^{\circ} \mathrm{C}$ <br> ${ }^{\circ} \mathrm{C}$ <br> ${ }^{\circ} \mathrm{C}$ <br> Degree <br> Degree <br> $\% / \mathrm{V}$ |
| OUTPUT VREF <br> Output Voltage, "F" <br> Output Voltage, "F" <br> Output Voltage, "F" <br> Drift <br> Line Regulation <br> Load Regulation <br> Output Current, Zero Hysteresis Hysteresis Current Scale Factor Turn-On Settling Time | VREF <br> VREF <br> VREF <br> TC ${ }_{\text {VREF }}$ <br> $\mathrm{I}_{\text {VREF }}$ <br> $\mathrm{SF}_{\mathrm{HYS}}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, No Load <br> $-40^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<85^{\circ} \mathrm{C}$, No Load <br> $-55^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<125^{\circ} \mathrm{C}$, No Load $\begin{aligned} & 4.5 \mathrm{~V} \leq \mathrm{V}+\leq 13.2 \mathrm{~V} \\ & 10 \mu \mathrm{~A} \leq \mathrm{I}_{\mathrm{VREF}} \leq 500 \mu \mathrm{~A} \end{aligned}$ <br> (Note 1) <br> To Rated Accuracy | $\begin{aligned} & 2.490 \\ & 2.480 \end{aligned}$ | $\begin{aligned} & 2.500 \\ & 2.500 \\ & 2.5 \pm 0.015 \\ & -10 \\ & \pm 0.01 \\ & \pm 0.1 \\ & 7 \\ & 5.0 \\ & 25 \end{aligned}$ | $\begin{aligned} & 2.510 \\ & 2.520 \\ & \\ & \pm 0.05 \\ & \pm 0.25 \end{aligned}$ | V <br> V <br> V <br> ppm $/{ }^{\circ} \mathrm{C}$ <br> $\% / \mathrm{V}$ <br> $\% / \mathrm{mA}$ <br> $\mu \mathrm{A}$ <br> $\mu \mathrm{A} /{ }^{\circ} \mathrm{C}$ <br> $\mu \mathrm{s}$ |
| OPEN-COLLECTOR OUTPUTS <br> Output Low Voltage Output Low Voltage Output Leakage Current Fall Time | R, UNDER <br> $\mathrm{V}_{\mathrm{OL}}$ <br> $\mathrm{V}_{\mathrm{OL}}$ <br> $\mathrm{I}_{\mathrm{OH}}$ <br> $\mathrm{t}_{\mathrm{HL}}$ | $\begin{aligned} & \mathrm{I}_{\text {SINK }}=1.6 \mathrm{~mA} \\ & \mathrm{I}_{\text {SINK }}=20 \mathrm{~mA} \\ & \mathrm{~V}+=12 \mathrm{~V} \end{aligned}$ <br> See Test Load, Note 2 |  | $\begin{aligned} & 0.25 \\ & 0.6 \\ & 1 \\ & 40 \end{aligned}$ | 0.4 100 | V <br> V <br> $\mu \mathrm{A}$ <br> ns |
| POWER SUPPLY <br> Supply Range Supply Current Supply Current Power Dissipation | $\begin{aligned} & \mathrm{V}+ \\ & \mathrm{I}_{\mathrm{SY}} \\ & \mathrm{I}_{\mathrm{SY}} \\ & \mathrm{P}_{\text {DISS }} \end{aligned}$ | Unloaded, $+\mathrm{V}=5 \mathrm{~V}$ <br> Unloaded, $+\mathrm{V}=13.2 \mathrm{~V}$ $+V=5 \cdot$ | 4.5 | $\begin{aligned} & 400 \\ & 450 \\ & 2.0 \end{aligned}$ | $\begin{aligned} & 13.2 \\ & 500 \\ & 800 \\ & 2.5 \end{aligned}$ | V <br> $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ <br> mW |

## NOTES

${ }^{1} \mathrm{~K}={ }^{\circ} \mathrm{C}+273.15$.
${ }^{2}$ Guaranteed but not tested.
${ }^{3}$ Does not consider errors caused by heating due to dissipation of output load currents.
${ }^{4}$ Maximum deviation between $+25^{\circ} \mathrm{C}$ readings after temperature cycling between $-55^{\circ} \mathrm{C}$ and $+125^{\circ} \mathrm{C}$.
${ }^{5}$ Typical values indicate performance measured at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.
${ }^{6}$ Observed in a group sample over an accelerated life test of 500 hours at $150^{\circ} \mathrm{C}$.
Specifications subject to change without notice.

WAFER TEST LIMITS $\left(v_{D O}=+5.0 \mathrm{~V}, \mathrm{GND}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right.$, unless otherwise noted)

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUTS SET HIGH, SET LOW Input Bias Current | $\mathrm{I}_{\mathrm{B}}$ |  |  |  | 100 | nA |
| OUTPUT VPTAT <br> Temperature Accuracy |  | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, No Load |  |  | 1.5 | ${ }^{\circ} \mathrm{C}$ |
| OUTPUT VREF <br> Nominal Value Line Regulation Load Regulation | VREF | $\begin{aligned} & \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \text { No Load } \\ & 4.5 \mathrm{~V} \leq \mathrm{V}+\leq 13.2 \mathrm{~V} \\ & 10 \mu \mathrm{~A} \leq \mathrm{I}_{\mathrm{VREF}} \leq 500 \mu \mathrm{~A} \end{aligned}$ | 2.490 |  | $\begin{aligned} & 2.510 \\ & \pm 0.05 \\ & \pm 0.25 \end{aligned}$ | V <br> \%/V <br> $\% / \mathrm{mA}$ |
| OPEN-COLLECTOR OUTPUTS <br> Output Low Voltage Output Low Voltage Output Leakage Current | UNDER <br> $\mathrm{V}_{\text {OL }}$ <br> $\mathrm{V}_{\mathrm{OL}}$ <br> $\mathrm{I}_{\mathrm{OH}}$ | $\begin{aligned} & \mathrm{I}_{\text {SINK }}=1.6 \mathrm{~mA} \\ & \mathrm{I}_{\text {SINK }}=20 \mathrm{~mA} \end{aligned}$ |  |  | $\begin{aligned} & 0.4 \\ & 1.0 \\ & 100 \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{mV} \\ & \mathrm{~V} \\ & \mu \mathrm{~A} \end{aligned}$ |
| POWER SUPPLY <br> Supply Range Supply Current | $\begin{aligned} & \mathrm{V}+ \\ & \mathrm{I}_{\mathrm{SY}} \end{aligned}$ | Unloaded | 4.5 |  | $\begin{aligned} & 13.2 \\ & 600 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mu \mathrm{~A} \end{aligned}$ |

## NOTES

Electrical tests are performed at wafer probe to the limits shown. Due to variations in assembly methods and normal yield loss, yield after packaging is not guaranteed for standard product dice. Consult factory to negotiate specifications based on dice lot qualification through sample lot assembly and testing.

## DICE CHARACTERISTICS

Die Size $0.078 \times 0.071$ inch, 5,538 sq. mils
$(1.98 \times 1.80 \mathrm{~mm}, 3.57 \mathrm{sq} . \mathrm{mm})$
Transistor Count: 105


For additional DICE ordering information, refer to databook.

ABSOLUTE MAXIMUM RATINGS
Maximum Supply Voltage . . . . . . . . . . . . . -0.3 V to +15 V
Maximum Input Voltage
(SETHIGH, SETLOW) . . . . . . . -0.3 V to $[(\mathrm{V}+)+0.3 \mathrm{~V}]$
Maximum Output Current (VREF, VPTAT) . . . . . . . . 2 mA
Maximum Output Current (Open Collector Outputs) . . 50 mA
Maximum Output Voltage (Open Collector Outputs) . . . . 15 V
Operating Temperature Range . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Dice Junction Temperature . . . . . . . . . . . . . . . . . . $+150^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 60 sec ) . . . . . . . . . . $+300^{\circ} \mathrm{C}$

| Package Type | $\boldsymbol{\theta}_{\mathbf{J A}}$ | $\boldsymbol{\theta}_{\mathbf{J C}}$ | Units |
| :--- | :--- | :--- | :--- |
| 8-Pin Plastic DIP (P) | $103^{1}$ | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Lead SOIC (S) | $158^{2}$ | 43 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Lead TO-99 Can (J) | $150^{1}$ | 18 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTES

${ }^{1} \theta_{\mathrm{JA}}$ is specified for device in socket (worst case conditions).
${ }^{2} \theta_{\text {JA }}$ is specified for device mounted on PCB.

## CAUTION

1. Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation at or above this specification is not implied. Exposure to the above maximum rating conditions for extended periods may affect device reliability.
2. Digital inputs and outputs are protected, however, permanent damage may occur on unprotected units from high energy electrostatic fields. Keep units in conductive foam or packaging at all times until ready to use. Use proper antistatic handling procedures.
3. Remove power before inserting or removing units from their sockets.

ORDERING GUIDE

| Model/Grade | Temperature <br> Range $^{\mathbf{1}}$ | Package <br> Description | Package <br> Option $^{2}$ |
| :--- | :--- | :--- | :--- |
| TMP01EP | XIND | Plastic DIP | N-8 |
| TMP01FP | XIND | Plastic DIP | N-8 |
| TMP01ES | XIND | SOIC | SO-8 |
| TMP01FS | XIND | SOIC | SO-8 |
| TMP01FJ ${ }^{3}$ | XIND | TO-99 Can | H-08A |
| TMP01GBC $^{25}$ 25 | Die |  |  |

## NOTES

${ }^{1}$ XIND $=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.
${ }^{2}$ For outline information see Package Information section.
${ }^{3}$ Consult factory for availability of MIL/883 version in TO-99 can.

## GENERAL DESCRIPTION

The TMP01 is a very linear voltage-output temperature sensor, with a window comparator that can be programmed by the user to activate one of two open-collector outputs when a predetermined temperature setpoint voltage has been exceeded. A low drift voltage reference is available for setpoint programming.

The temperature sensor is basically a very accurately temperaturecompensated, bandgap-type voltage reference with a buffered output voltage proportional to absolute temperature (VPTAT), accurately trimmed to a scale factor of $5 \mathrm{mV} / \mathrm{K}$. See the applications information following.
The low drift 2.5 V reference output VREF is easily divided externally with fixed resistors or potentiometers to accurately establish the programmed heat/cool setpoints, independent of temperature. Alternatively, the setpoint voltages can be supplied by other ground-referenced voltage sources such as userprogrammed DACs or controllers. The high and low setpoint voltages are compared to the temperature sensor voltage, thus creating a two-temperature thermostat function. In addition, the total output current of the reference ( $\mathrm{I}_{\mathrm{VREF}}$ ) determines the magnitude of the temperature hysteresis band. The opencollector outputs of the comparators can be used to control a wide variety of devices.


Figure 1. Detailed Block Diagram

## TMP01

## Temperature Hysteresis

The temperature hysteresis is the number of degrees beyond the original setpoint temperature that must be sensed by the TMP01 before the setpoint comparator will be reset and the output disabled. Figure 2 shows the hysteresis profile. The hysteresis is programmed by the user by setting a specific load on the reference voltage output VREF. This output current $\mathrm{I}_{\text {VREF }}$ is also called the hysteresis current, which is mirrored internally and fed to a buffer with an analog switch.


Figure 2. TMP01 Hysteresis Profile
After a temperature setpoint has been exceeded and a comparator tripped, the buffer output is enabled. The output is a current of the appropriate polarity which generates a hysteresis offset voltage across an internal $1000 \Omega$ resistor at the comparator input. The comparator output remains "on" until the voltage at the comparator input, now equal to the temperature sensor voltage VPTAT summed with the hysteresis offset, has returned to the programmed setpoint voltage. The comparator then returns LOW, deactivating the open-collector output and disabling the hysteresis current buffer output. The scale factor for the programmed hysteresis current is:

$$
I_{H Y S}=I_{V R E F}=5 \mu A /{ }^{\circ} C+7 \mu A
$$

Thus since VREF $=2.5 \mathrm{~V}$, with a reference load resistance of $357 \mathrm{k} \Omega$ or greater (output current $7 \mu \mathrm{~A}$ or less), the temperature setpoint hysteresis will be zero degrees. See the temperature programming discussion below. Larger values of load resistance will only decrease the output current below $7 \mu \mathrm{~A}$ and will have no effect on the operation of the device. The amount of hysteresis is determined by selecting a value of load resistance for VREF, as shown below.

## Programming the TMP01

In the basic fixed-setpoint application utilizing a simple resistor ladder voltage divider, the desired temperature setpoints are programmed in the following sequence:

1. Select the desired hysteresis temperature.
2. Calculate the hysteresis current $\mathrm{I}_{\text {VREF }}$.

3 Select the desired setpoint temperatures.
4. Calculate the individual resistor divider ladder values needed to develop the desired comparator setpoint voltages at SETHIGH and SETLOW.

The hysteresis current is readily calculated, as shown above. For example, for 2 degrees of hysteresis, $\mathrm{I}_{\text {VREF }}=17 \mu \mathrm{~A}$. Next, the setpoint voltages $\mathrm{V}_{\text {SETHIGH }}$ and $\mathrm{V}_{\text {SETLOw }}$ are determined using the VPTAT scale factor of $5 \mathrm{mV} / \mathrm{K}=5 \mathrm{mV} /\left({ }^{\circ} \mathrm{C}+273.15\right)$,
which is 1.49 V for $+25^{\circ} \mathrm{C}$. We then calculate the divider resistors, based on those setpoints. The equations used to calculate the resistors are:

$$
\begin{aligned}
V_{\text {SETHIGH }}= & \left(T_{\text {SETHIGH }}+273.15\right)\left(5 \mathrm{mV} /{ }^{\circ} \mathrm{C}\right) \\
V_{\text {SETLOW }}= & \left(T_{\text {SETLOW }}+273.15\right)\left(5 \mathrm{mV} /{ }^{\circ} \mathrm{C}\right) \\
R 1(k \Omega)= & \left(V_{\text {VREF }}-V_{\text {SETHIGH }}\right) / I_{\text {VREF }}= \\
& \left(2.5 V-V_{\text {SETHIGH }}\right) / I_{V R E F} \\
R 2(k \Omega)= & \left(V_{\text {SETHIGH }}-V_{\text {SETLOW }}\right) / I_{V R E F} \\
R 3(k \Omega)= & V_{\text {SETLOW }} / I_{\text {VREF }}
\end{aligned}
$$



Figure 3. TMP01 Setpoint Programming
The total $\mathbf{R} 1+\mathbf{R} 2+\mathbf{R} 3$ is equal to the load resistance needed to draw the desired hysteresis current from the reference, or $\mathrm{I}_{\text {VREF }}$.
The formulas shown above are also helpful in understanding the calculation of temperature setpoint voltages in circuits other than the standard two-temperature thermostat. If a setpoint function is not needed, the appropriate comparator should be disabled. SETHIGH can be disabled by tying it to $\mathrm{V}+$, SETLOW by tying it to GND. Either output can be left unconnected.


Figure 4. Temperature-VPTAT Scale

## Understanding Error Sources

The accuracy of the VPTAT sensor output is well characterized and specified, however preserving this accuracy in a heating or cooling control system requires some attention to minimizing the various potential error sources. The internal sources of setpoint programming error include the initial tolerances and temperature drifts of the reference voltage VREF, the setpoint comparator input offset voltage and bias current, and the hysteresis current scale factor. When evaluating setpoint programming errors, remember that any VREF error contribution at the comparator inputs is reduced by the resistor divider ratios. The comparator input bias current (inputs SETHIGH, SETLOW) drops to less than 1 nA (typ) when the comparator is tripped. This can account for some setpoint voltage error, equal to the change in bias current times the effective setpoint divider ladder resistance to ground.

The thermal mass of the TMP01 package and the degree of thermal coupling to the surrounding circuitry are the largest factors in determining the rate of thermal settling, which ultimately determines the rate at which the desired temperature measurement accuracy may be reached. Thus, one must allow sufficient time for the device to reach the final temperature. The typical thermal time constant for the plastic package is approximately 140 seconds in still air! Therefore, to reach the final temperature accuracy within $1 \%$, for a temperature change of 60 degrees, a settling time of 5 time constants, or 12 minutes, is necessary.
The setpoint comparator input offset voltage and zero hysteresis current affect setpoint error. While the $7 \mu \mathrm{~A}$ zero hysteresis current allows the user to program the TMP01 with moderate resistor divider values, it does vary somewhat from device to device, causing slight variations in the actual hysteresis obtained in
practice. Comparator input offset directly impacts the programmed setpoint voltage and thus the resulting hysteresis band, and must be included in error calculations.

External error sources to consider are the accuracy of the external programming resistors, grounding error voltages, comparator input noise, comparator input bias current, and the overall problem of thermal gradients. The accuracy of the external programming resistors directly impacts the resulting setpoint accuracy. Thus in fixed-temperature applications the user should select resistor tolerances appropriate to the desired programming accuracy. Resistor temperature drift must be taken into account also. This effect can be minimized by selecting good quality components, and by keeping all components in close thermal proximity. Applications requiring high measurement accuracy require great attention to detail regarding thermal gradients. Careful circuit board layout, component placement, and protection from stray air currents are necessary to minimize common thermal error sources.
Also, the user should take care to keep the bottom of the setpoint programming divider ladder as close to GND (Pin 4) as possible to minimize errors due to IR voltage drops and coupling of external noise sources. In any case, $\mathrm{a} 0.1 \mu \mathrm{~F}$ capacitor for power supply bypassing is always recommended at the chip.
Safety Considerations In Heating And Cooling System Design Designers should anticipate potential system fault conditions which may result in significant safety hazards which are outside the control of and cannot be corrected by the TMP01-based circuit. Governmental and industrial regulations regarding safety requirements and standards for such designs should be observed where applicable.


Figure 5. Supply Current vs. Supply Voltage


Figure 6. Minimum Supply Voltage vs. Temperature


Figure 7. VPTAT Accuracy vs. Temperature


Figure 8. VREF Accuracy vs. Temperature


Figure 9. Open-Collector Output ( $\overline{O V E R}, \overline{U N D E R})$ Saturation Voltage vs. Output Current


Figure 10. VREF Long Term Drift Accelerated by Burn-In


Figure 11. VREF Power Supply Rejection vs. Frequency


Figure 12. Set High, Set Low Input Offset Voltage vs. Temperature


Figure 13. Comparator Input Offset Distribution


Figure 14. Zero Hysteresis Current Distribution

## APPLICATIONS INFORMATION

## Self-Heating Effects

In some applications the user should consider the effects of selfheating due to the power dissipated by the open-collector outputs, which are capable of sinking 20 mA continuously. Under full load, the TMP01 open-collector output device is dissipating

$$
P_{D I S S}=0.6 \mathrm{~V} \times .020 \mathrm{~A}=12 \mathrm{~mW}
$$

which in a surface-mount SO package accounts for a temperature increase due to self-heating of

$$
\Delta T=P_{D I S S} \times \theta_{\mathscr{F} A}=.012 \mathrm{~W} \times 158^{\circ} \mathrm{C} / W=1.9^{\circ} \mathrm{C}
$$

This will of course directly affect the accuracy of the TMP01 and will for example cause the device to switch the heating output "OFF" 2 degrees early. Alternatively, bonding the same package to a moderate heatsink limits the self-heating effect to approximately

$$
\Delta T=P_{D I S S} \times \theta_{\mathscr{F} C}=.012 \mathrm{~W} \times 43^{\circ} \mathrm{C} / \mathrm{W}=0.52^{\circ} \mathrm{C}
$$

which is a much more tolerable error in most systems. The VREF and VPTAT outputs are also capable of delivering sufficient current to contribute heating effects and should not be ignored.

## Buffering the Voltage Reference

As mentioned above, the reference output VREF is used to generate the temperature setpoint programming voltages for the TMP01 and also is used to determine the hysteresis temperature band by the reference load current $\mathrm{I}_{\text {VREF }}$. The on-board output buffer amplifier is typically capable of $500 \mu \mathrm{~A}$ output drive into as much as 50 pF load (max). Exceeding this load will affect the accuracy of the reference voltage, could cause thermal sensing errors due to dissipation, and may induce oscillations. Selection of a low drift buffer functioning as a voltage follower with high input impedance will ensure optimal reference accuracy, and will not affect the programmed hysteresis current. Amplifiers which offer the low drift, low power consumption, and low cost appropriate to this application include the OP295, and members of the OP90, OP97, OP177 families, and others as shown in the following applications circuits.
With excelient drift and noise characteristics, $\mathrm{V}_{\text {REF }}$ offers a good voltage reference for data acquisition and transducer excitation applications as well. Output drift is typically better than $-10 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$, with $315 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ (typ) noise spectral density at 1 kHz .

## Preserving Accuracy Over Wide Temperature Range Operation

The TMP01 is unique in offering both a wide-range temperature sensor and the associated detection circuitry needed to implement a complete thermostatic control function in one monolithic device. While the voltage reference, setpoint comparators, and output buffer amplifiers have been carefully compensated to maintain accuracy over the specified temperature range, the user has an additional task in maintaining the accuracy over wide operating temperature ranges in his application. Since the TMP01 is both sensor and control circuit, in many applications it is possible that the external components used to program and interface the device may be subjected to the same temperature extremes. Thus it may be necessary to locate components in close thermal proximity to minimize large temperature differentials, and to account for thermal drift errors where appropriate, such as resistor matching tempcos, amplifier error drift, and the like. Circuit design with the TMP01 requires a sightly different perspective regarding the thermal behavior of electronic components.

## Thermal Response Time

The time required for a temperature sensor to settle to a specified accuracy is a function of the thermal mass of, and the thermal conductivity between the sensor and the object being sensed. Thermal mass is often considered equivalent to capacitance. Thermal conductivity is commonly specified using the symbol $Q$, and can be thought of as thermal resistance. It is commonly specified in units of degrees per watt of power transferred across the thermal joint. Thus, the time required for the TMP01 to settle to the desired accuracy is dependent on the package selected, the thermal contact established in that particular application, and the equivalent power of the heat source. In most applications, the settling time is probably best determined empirically.

## Switching Loads With The Open-Collector Outputs

In many temperature sensing and control applications some type of switching is required. Whether it be to turn on a heater when the temperature goes below a minimum value or to turn off a motor that is overheating, the open-collector outputs Over and Under can be used. For the majority of applications, the switches used need to handle large currents on the order of 1 Amp and above. Because the TMP01 is accurately measuring temperature, the open-collector outputs should handle less than 20 mA of current to minimize self-heating. Clearly, the Overtemp and Undertemp outputs should not drive the equipment directly. Instead, an external switching device is required to handle the large currents. Some examples of these are relays, power MOSFETs, thyristors, IGBTs, and Darlingtons.
Figure 15 shows a variety of circuits where the TMP01 controls a switch. The main consideration in these circuits, such as the relay in Figure 15a, is the current required to activate the switch.


Figure 15a. Reed Relay Drive
It is important to check the particular relay you choose to ensure that the current needed to activate the coil does not exceed the TMP01's recommended output current of 20 mA . This is easily determined by dividing the relay coil voltage by the specified coil resistance. Keep in mind that the inductance of the relay will create large voltage spikes that can damage the TMP01 output unless protected by a commutation diode across the coil, as shown. The relay shown has a contact rating of 10 watts maximum. If a relay capable of handling more power is desired, the larger contacts will probably require a commensurately larger coil, with lower coil resistance and thus higher trigger current. As the contact power handling capability increases, so does the current needed for the coil. In some cases an external driving transistor should be used to remove the current load on the TMP01 as explained in the next section.
Power FETs are popular for handling a variety of high current DC loads. Figure 15b shows the TMP01 driving a p-channel MOSFET transistor for a simple heater circuit. When the output transistor turns on, the gate of the MOSFET is pulled down to approximately 0.6 V , turning it on. For most MOSFETs a gate-to-source voltage or Vgs on the order of -2 V to -5 V is sufficient to turn the device on. Figure 15 c shows a similar circuit for turning on an n-channel MOSFET, except that now the gate to source voltage is positive. Because of this reason an external transistor must be used as an inverter so that the MOSFET will turn on when the "Under Temp" output pulls down.


Figure 15b. Driving a P-Channel MOSFET


Figure 15c. Driving a N-Channel MOSFET
Isolated Gate Bipolar Transistors (IGBT) combine many of the benefits of power MOSFETs with bipolar transistors, and are used for a variety of high power applications. Because IGBTs have a gate similar to MOSFETs, turning on and off the devices is relatively simple as shown in Figure 15d. The turn on voltage for the IGBT shown (IRGBC40S) is between 3.0 and 5.5 volts. This part has a continuous collector current rating of 50 A and a maximum collector to emitter voltage of 600 V , enabling it to work in very demanding applications.


Figure 15d. Driving an IGBT

The last class of high power devices discussed here are Thyristors, which includes SCRs and Triacs. Triacs are a useful alternative to relays for switching ac line voltages. The 2N6073A shown in Figure 15e is rated to handle 4A (rms). The optoisolated MOC3021 Triac shown features excellent electrical isolation from the noisy ac line and complete control over the high power Triac with only a few additional components.


Figure 15e. Controlling the 2N6073A Triac

## High Current Switching

As mentioned above, internal dissipation due to large loads on the TMP01 outputs will cause some temperature error due to self-heating. External transistors remove the load from the TMP01, so that virtually no power is dissipated in the internal transistors and no self-heating occurs. Figure 16 shows a few examples using external transistors. The simplest case, using a single transistor on the output to invert the output signal is shown in Figure 16a. When the open-collector of the TMP01 turns "ON" and pulls the output down, the external transistor Q1's base will be pulled low, turning off the transistor. Another


Figure 16a. An External Resistor Minimizes Self-Heating
transistor can be added to reinvert the signal as shown in Figure 16b. Now, when the output of the TMP01 is pulled down, the first transistor, Q1, turns off and its collector goes high, which turns Q2 on, pulling its collector low. Thus, the output taken from the collector of Q2 is identical to the output of the TMP01. By picking a transistor that can accommodate large amounts of current, many high power devices can be switched.


Figure 16b. Second Transistor Maintains Polarity of TMP01 Output

An example of a higher power transistor is a standard Darlington configuration as shown in Figure 16c. The part chosen, TIP-110, can handle 2A continuous which is more than enough to control many high power relays. In fact the Darlington itself can be used as the switch, similar to MOSFETs and IGBTs.


Figure 16c. Darlington Transistor Can Handle Large Currents

## Buffering the Temperature Output Pin

The VPTAT sensor output is a low impedance dc output voltage with a $5 \mathrm{mV} / \mathrm{K}$ temperature coefficient, and is useful in a number of measurement and control applications. In many applications, this voltage needs to be transmitted to a central location for processing. The buffered VPTAT voltage output is capable of $500 \mu \mathrm{~A}$ drive into 50 pF (max). As mentioned in the discussion above regarding buffering circuits for the VREF output, it is useful to consider external amplifiers for interfacing VPTAT to external circuitry to ensure accuracy, and to minimize loading which could create dissipation-induced temperature sensing errors. An excellent general-purpose buffer circuit using the OP177 is shown in Figure 17 which is capable of driving over 10 mA , and will remain stable under capacitive loads of up to $0.1 \mu \mathrm{~F}$. Other interfacing ideas are shown below.

## Differential Transmitter

In noisy industrial environments, it is difficult to send an accurate analog signal over a significant distance. However, by sending the signal differentially on a wire pair, these errors can be significantly reduced. Since the noise will be picked up equally on both wires, a receiver with high common-mode input rejection can be used to cancel out the noise very effectively at the


Figure 17. Buffer VPTAT to Handle Difficult Loads
receiving end. Figure 18 shows two amplifiers being used to send the signal differentially, and an excellent differential receiver, the AMP03, which features a common mode rejection ratio of 95 dB at dc and very low input and drift errors.


Figure 18. Send the Signal Differentially for Noise Immunity

## $4 \mathrm{~mA}-20 \mathrm{~mA}$ Current Loop

Another, very common method of transmitting a signal over long distances is to use a $4 \mathrm{~mA}-20 \mathrm{~mA}$ Loop, as shown in Figure 19. An advantage of using a $4 \mathrm{~mA}-20 \mathrm{~mA}$ loop is that the accuracy of a current loop is not compromised by voltage drops across the line. One requirement of $4 \mathrm{~mA}-20 \mathrm{~mA}$ circuits is that the remote end must receive all of its power from the loop, meaning that the circuit must consume less than 4 mA . Operating from +5 V , the quiescent current of the TMP 01 is $500 \mu \mathrm{~A}$ max, and the OP90's is $20 \mu \mathrm{~A}$ max, totaling less than 4 mA . Although not shown, the open collector outputs and temperature setting pins can be connected to do any local control of switching.
The current is proportional to the voltage on the VPTAT output, and is calibrated to 4 mA at a temperature of $-40^{\circ} \mathrm{C}$, to 20 mA for $+85^{\circ} \mathrm{C}$. The main equation governing the operation of this circuit gives the current as a function of VPTAT:

$$
I_{O U T}=\frac{1}{R_{6}}\left(\frac{V P T A T \times R_{5}}{R_{2}}-\frac{V R E F \times R_{3}}{R_{3}+R_{1}}\left(1+\frac{R_{5}}{R_{2}}\right)\right)
$$

The resulting temperature coefficient of the output current is $128 \mu \mathrm{~A} /{ }^{\circ} \mathrm{C}$.


Figure 19. 4-20 mA Current Loop
To determine the resistor values in this circuit, first note that VREF remains constant over temperature. Thus the ratio of R5 over R2 must give a variation of $\mathrm{I}_{\text {OUT }}$ from 4 mA to 20 mA as VPTAT varies from 1.165 V at $-40^{\circ} \mathrm{C}$ to 1.79 V at $+85^{\circ} \mathrm{C}$. The absolute value of the resistors is not important, only the ratio. For convenience, $100 \mathrm{k} \Omega$ is chosen for R 5 . Once R 2 is calculated, the value of R3 and R1 is determined by substituting 4 mA for $\mathrm{I}_{\text {OUT }}$ and 1.165 V for VPTAT and solving. The final values are shown in the circuit. The OP90 is chosen for this circuit because of its ability to operate on a single supply and its high accuracy. For initial accuracy, a $10 \mathrm{k} \Omega$ trim potentiometer can be included in series with R3, and the value of R3 lowered to $95 \mathrm{k} \Omega$. The potentiometer should be adjusted to produce an output current of 12.3 mA at $25^{\circ} \mathrm{C}$.

## Temperature-to-Frequency Converter

Another common method of transmitting analog information is to convert a voltage to the frequency domain. This is easily done with any of the low cost monolithic Voltage-to-Frequency Converters (VFCs) available, which feature a robust, open-collector digital output. A digital signal is very immune to noise and voltage drops because the only important information is the frequency. As long as the conversions between temperature and frequency are done accurately, the temperature data can be successfully transmitted.
A simple circuit to do this combines the TMP01 with an AD654 VFC, as shown in Figure 20. The AD654 outputs a square wave that is proportional to the dc input voltage according to the following equation:

$$
F_{\text {OUT }}=\frac{V_{I N}}{10\left(R_{1}+R_{2}\right) C_{T}}
$$

By simply connecting the VPTAT output to the input of the AD654, the $5 \mathrm{mV} /{ }^{\circ} \mathrm{C}$ temperature coefficient gives a sensitivity of $25 \mathrm{~Hz} /{ }^{\circ} \mathrm{C}$, centered around 7.5 kHz at $25^{\circ} \mathrm{C}$. The trimming resistor R2 is needed to calibrate the absolute accuracy of the AD654. For more information on that part, please consult the AD654 data sheet. Finally, the AD650 can be used to accurately convert the frequency back to a dc voltage on the receiving end.


Figure 20. Temperature-to-Frequency Converter

## Isolation Amplifier

In many industrial applications the sensor is located in an environment that needs to be electrically isolated from the central processing area. Figure 21 shows a simple circuit that uses an 8 -pin optoisolator (IL300XC) that can operate across a $5,000 \mathrm{~V}$ barrier. IC1 (an OP290 single-supply amplifier) is used to drive the LED connected between Pins 1 to 2. The feedback actually


Figure 21. Isolation Amplifier
comes from the photodiode connected from Pins 3 to 4. The OP290 drives the LED such that there is enough current generated in the photodiode to exactly equal the current derived from the VPTAT voltage across the $470 \mathrm{k} \Omega$ resistor. On the receiving end, an OP90 converts the current from the second photodiode to a voltage through its feedback resistor R2. Note that the other amplifier in the dual OP290 is used to buffer the 2.5 V reference voltage of the TMP01 for an accurate, low drift LED bias level without affecting the programmed hysteresis current. A REF43 (a precision 2.5 V reference) provides an accurate bias level at the receiving end.
To understand this circuit, it helps to examine the overall equation for the output voltage. First, the current (Il) in the photodiode is set by:

$$
I_{1}=\frac{2.5 V-V P T A T}{470 k \Omega}
$$

Note that the IL300XC has a gain of 0.73 (typical) with a min and max of 0.693 and 0.769 respectively. Since this is less than $1.0, \mathrm{R} 2$ must be larger than R1 to achieve overall unity gain. To show this the full equation is:
$V_{\text {OUT }}=2.5 V-I_{2} R_{2}=2.5 V-0.7\left(\frac{2.5 V-V P T A T}{470 k \Omega}\right) 644 k \Omega=V P T A T$

A trim is included for R2 to correct for the initial gain accuracy of the IL300XC. To perform this trim, simply adjust for an output voltage equal to VPTAT at any particular temperature. For example, at room temperature, VPTAT $=1.49 \mathrm{~V}$, so adjust R2 until $\mathrm{V}_{\text {OUT }}=1.49 \mathrm{~V}$ as well. Both the REF43 and the OP90 operate from a single supply, and contribute no significant error due to drift.

In order to avoid the accuracy trim, and to reduce board space, complete isolation amplifiers are available, such as the high accuracy AD202.

## Out-of-Range Warning

By connecting the two open collector outputs of the TMP01 together into a "wired-OR" configuration, a temperature "out-of-range" warning signal is generated. This can be useful in sensitive equipment calibrated to work over a limited temperature range. R1, R2, and R3 in Figure 22 are chosen to give a temperature range of $10^{\circ} \mathrm{C}$ around room temperature $\left(25^{\circ} \mathrm{C}\right)$. Thus, if the temperature in the equipment falls below $+15^{\circ} \mathrm{C}$ or rises above $+35^{\circ} \mathrm{C}$, the Undertemp Output or Overtemp Output


Figure 22. Out-of-Range Warning
respectively will go low and turn the LED on. The LED may be replaced with a simple pull-up resistor to give a logic output for controlling the instrument, or any of the switching devices discussed above can be used.

## Translating $5 \mathrm{mV} / \mathrm{K}$ to $10 \mathrm{mV} /{ }^{\circ} \mathrm{C}$

A useful circuit is shown in Figure 23 that translates the VPTAT output voltage, which is calibrated in Kelvins, into an output that can be read directly in degrees Celsius on a voltmeter display. To accomplish this, an external amplifier is configured as a differential amplifier. The resistors are scaled so the VREF voltage will exactly cancel the VPTAT voltage at $0.0^{\circ} \mathrm{C}$.


Figure 23. Translating $5 \mathrm{mV} / \mathrm{K}$ to $10 \mathrm{mV} /{ }^{\circ} \mathrm{C}$

However, the gain from VPTAT to the output is two, so that $5 \mathrm{mV} / \mathrm{K}$ becomes $10 \mathrm{mV} /{ }^{\circ} \mathrm{C}$. Thus, for a temperature of $+80^{\circ} \mathrm{C}$, the output voltage is 800 mV . Circuit errors will be due primarily to the inaccuracies of the resistor values. Using $1 \%$ resistors the observed error was less than 10 mV , or $1^{\circ} \mathrm{C}$. The 10 pF feedback capacitor helps to ensure against oscillations. For better accuracy, a adjustment potentiometer can be added in series with either $100 \mathrm{k} \Omega$ resistor.

## Translating VPTAT to the Fahrenheit Scale

A very similar circuit to the one shown in Figure 23 can be used to translate VPTAT into an output that can be read directly in degrees Fahrenheit, with a scaling of $10 \mathrm{mV} /{ }^{\circ} \mathrm{F}$. Only unity gain or less is available from the first stage differentiating circuit, so the second amplifier provides a gain of two to complete the conversion to the Fahrenheit scale. Using the circuit in Figure 24, a temperature of $0.0^{\circ} \mathrm{F}$ gives an output of 0.00 V . At room temperature $\left(70^{\circ} \mathrm{F}\right)$ the output voltage is $700 \mathrm{mV} . \mathrm{A}-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ operating range translates into $-40^{\circ} \mathrm{F}$ to $+185^{\circ} \mathrm{F}$. The errors are essentially the same as for the circuit in Figure 23.


Figure 24. Translating $5 \mathrm{mV} / \mathrm{K}$ to $10 \mathrm{mV} /{ }^{\circ} \mathrm{F}$

## FEATURES

Modulated Serial Digital Output Proportional to Temperature $\pm 1.2^{\circ} \mathrm{C}$ Accuracy Over Temperature (typ) Specified $\mathbf{4} \mathbf{0}^{\circ} \mathrm{C}$ to $+100^{\circ} \mathrm{C}$, Operation to $150^{\circ} \mathrm{C}$<br>Power Consumption 3.5 mW at 5 V<br>No External Components<br>Flexible Open Collector Output (TMP03)<br>CMOS/TTL Compatible Output on TMP03L<br>Low Voltage Operation ( 4.5 V to 7 V )<br>Low Cost 3-Pin Packages

APPLICATIONS
Isolated Sensors
Environmental Control Systems
Thermal Protection
Industrial Process Control
Power System Monitors

## GENERAL DESCRIPTION

The TMP03/TMP03L is a monolithic temperature detector that generates a modulated serial digital output which varies in direct proportion to the temperature of the device. An onboatd sensor generates a voltage precisely proportional to absolute temperature which is input to a precision digital modulator. The ratiometric encoding format of the serial digital output is independent of the clock drift errors common to most serial modulation techniques such as voltage-to-frequency converters. Overall accuracy is $\pm 1.2$ degrees (typical) over the rated operating temperature range, with excellent transducer linearity. The digital output of the TMP03L is CMOS/TTL compatible and is easily interfaced to the serial inputs of most popular microprocessors. The open collector output of the TMP03 is capable of sinking 20 mA and is suitable for industrial systems including isolated circuits utilizing opto-couplers or isolation transformers.
The TMP03 and the TMP03L are specified for operation at supply voltages from 4.5 V to 7 V . Operating from +5 V , supply current (unloaded) is less than $700 \mu \mathrm{~A}$ (max).

FUNCTIONAL BLOCK DIAGRAM

*Patent pending.

This is a preliminary data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

## 

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ACCURACY <br> Scale Factor Deviation "E" <br> Scale Factor Deviation "F" <br> Scale Factor Deviation "E" <br> Scale Factor Deviation "F" <br> Nominal Duty Cycle <br> Power Supply Rejection Ratio | PSRR | $\begin{aligned} & 0^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<40^{\circ} \mathrm{C}^{1} \\ & 0^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<40^{\circ} \mathrm{C}^{1} \end{aligned}$ <br> Over Rated Temperature ${ }^{1}$ Over Rated Temperature ${ }^{1}$ $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ <br> Over Rated Supply |  | $\begin{aligned} & 0.6 \\ & 0.8 \\ & 1.2 \\ & 1.8 \\ & 42.2 \\ & 0.05 \end{aligned}$ | $\begin{aligned} & 1.2 \\ & 2.4 \\ & 2.2 \\ & 2.8 \end{aligned}$ | ${ }^{\circ} \mathrm{C}$ <br> ${ }^{\circ} \mathrm{C}$ <br> ${ }^{\circ} \mathrm{C}$ <br> ${ }^{\circ} \mathrm{C}$ <br> \% <br> \%/V |
| OUTPUTS <br> Output Low Voltage <br> Output Low Voltage <br> Digital Output Capacitance <br> Fall Time <br> Device Turn-On Time | $\mathrm{V}_{\text {OL }}$ <br> $\mathrm{V}_{\mathrm{oL}}$ <br> $\mathrm{C}_{\text {out }}$ <br> $\mathrm{t}_{\mathrm{HL}}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{SINK}}=1.6 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{SINK}}=15 \mathrm{~mA} \\ & \text { (Note 3) } \\ & \text { See Test Load } \end{aligned}$ |  | $\begin{aligned} & 15 \\ & 20 \end{aligned}$ | $\begin{aligned} & 0.2 \\ & 1 \\ & 250 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{pF} \\ & \mathrm{~ns} \\ & \mathrm{~ms} \end{aligned}$ |
| POWER SUPPLY <br> Supply Range Supply Current | $\begin{aligned} & \mathrm{V}+ \\ & \mathrm{I}_{\mathrm{SY}} \end{aligned}$ | Unloaded | $4.5$ |  | $\begin{aligned} & 7 \\ & 700 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mu \mathrm{~A} \end{aligned}$ |

NOTES
${ }^{1}$ Maximum deviation from output duty cycle transfer function over specified temperature range
${ }^{2}$ Does not consider errors caused by heating due to dissipation of output load currents,
${ }^{3}$ Guaranteed but not tested.
Specifications subject to change without notice.

## TMPO3LE/TMPO3LF-SPEGFFIGATVNG $\left(\mathrm{V}+=+5 \mathrm{~V},-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+100^{\circ} \mathrm{C}\right.$ unless otherwise noted $)$

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ACCURACY <br> Scale Factor Deviation "E" <br> Scale Factor Deviation "F" <br> Scale Factor Deviation "E" <br> Scale Factor Deviation " $F$ " <br> Nominal Duty Cycle <br> Power Supply Rejection Ratio | PSRR | $\begin{aligned} & 0^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<40^{\circ} \mathrm{C} \\ & 0^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<40^{\circ} \mathrm{C} \end{aligned}$ <br> Over Rated Temperature ${ }^{1}$ Over Rated Temperature ${ }^{1}$ $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ <br> Over Rated Supply |  | $\begin{aligned} & 0.6 \\ & 0.8 \\ & 1.2 \\ & 1.8 \\ & 42.2 \\ & 0.05 \end{aligned}$ | $\begin{aligned} & 1.2 \\ & 2.4 \\ & 2.2 \\ & 2.8 \end{aligned}$ | $\begin{aligned} & { }^{\circ} \mathrm{C} \\ & { }^{\circ} \mathrm{C} \\ & { }^{\circ} \mathrm{C} \\ & { }^{\circ} \mathrm{C} \\ & \% \\ & \% / \mathrm{V} \end{aligned}$ |
| OUTPUTS <br> Output High Voltage <br> Output Low Voltage <br> Digital Output Capacitance <br> Fall Time <br> Rise Time <br> Device Turn-On Time | $\mathrm{V}_{\mathrm{OH}}$ <br> $\mathrm{V}_{\mathrm{OL}}$ <br> Cout <br> $\mathrm{t}_{\mathrm{HL}}$ <br> $t_{\text {LH }}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{OH}}=800 \mu \mathrm{~A} \\ & \mathrm{I}_{\mathrm{OL}}=800 \mu \mathrm{~A} \end{aligned}$ <br> (Note 3) <br> See Test Load <br> See Test Load | $\mathrm{V}+-0.4$ | $15$ $20$ | $\begin{aligned} & 400 \\ & 250 \\ & 250 \end{aligned}$ | V <br> mV <br> pF <br> ns <br> ns <br> ms |
| POWER SUPPLY <br> Supply Range <br> Supply Current | $\begin{aligned} & \text { V+ } \\ & \mathrm{I}_{\mathrm{SY}} \end{aligned}$ | Unloaded | 4.5 |  | $\begin{aligned} & 7 \\ & 700 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mu \mathrm{~A} \end{aligned}$ |

[^264]This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

## TMP03/TMP03L

## GENERAL DESCRIPTION (continued)

The TMP03/TMP03L is a powerful, complete temperature measurement system with digital output, on a single chip. The onboard temperature sensor follows in the footsteps of the TMP01 low power, programmable temperature controller, offering excellent accuracy and linearity over the entire rated temperature range without correction or calibration by the user.

The sensor output is digitized by an advanced first order sigmadelta modulator, also known as the "charge balance" type analog-to-digital converter. See Figure 1. This type of converter utilizes time domain oversampling and a high accuracy comparator to deliver 12 bits of effective accuracy in an extremely compact circuit


Figure 1. First-Order Sigma-Delta Modulator Basically, the sigma-delta modulator consists of an input sample-and-hold, a summing amplifier, an integrator, a comparator, and a 1-bit DAC. Similar to the voltage-to-frequency converter, this architecture creates in effect a negative feedback loop whose intent is to minimize the integrator output by changing the duty cycle of the comparator output in response to input voltage changes. The comparator samples the output of the integrator at a much higher rate than the input sampling frequency, called oversampling. This spreads the quantization noise over a much wider band than that of the input signal, improving overall noise performance and increasing accuracy.
The modulated output of the comparator is encoded using a patented technique which results in a serial digital signal with a ratiometric duty cycle format which is easily decoded by any microprocessor into either degrees Centigrade or degrees Fahrenheit values, and readily transmitted or modulated over a single wire. Most importantly, this encoding method neatly avoids major error sources common to other modulation techniques, as it is clock independent.

## Output Encoding

Accurate sampling of an analog signal requires precise spacing of the sampling interval in order to maintain an accurate representation of the signal in the time domain. This dictates a master clock between the digitizer and the signal processor. In the case of compact, cost-effective data acquisition systems, the addition of a buffered high speed clock line can represent a significant burden on the overall system design. Alternatively, the addition of an onboard clock circuit with the appropriate accuracy and drift performance to an integrated circuit can add significant cost. The modulation and encoding techniques utilized in the TMP03/TMP03L avoid this problem and allow the overall circuit to fit into a compact, three-pin package. To achieve this, a simple, compact onboard clock and an oversampling digitizer which is insensitive to sampling rate variations are used.

Most importantly, the digitized signal is encoded into a ratiometric format in which the exact frequency of the TMP03/ TMP03L's clock is irrelevant, and the effects of clock variations at the counter are effectively cancelled upon decoding.
The output of the TMP03/TMP03L is a square wave with a nominal frequency of 45 Hz . The output format is readily decoded by the user as follows:


Figure 2. TMP03/TMPO3L Output Format

$$
\begin{aligned}
& \text { Temperature }\left({ }^{\circ} \mathrm{C}\right)=260-\left(\frac{450 \times T 1}{T 2}\right) \\
& \text { Temperature }\left({ }^{\circ} F\right)=500-\left(\frac{810 \times T 1}{T 2}\right)
\end{aligned}
$$

where the time period T 1 (low period) and T 2 (high period) are counter values easily read by a microprocessor input port, and the above calculations performed in software. Since both periods are obtained consecutively, using the same clock, performing the division indicated in the above formulas results in a ratiometric value that is independent of the exact frequencies of, or drift in, either the originating clock of the TMP03 or the user's counting clock.
A period counting clock of approximately 1 MHz (or higher) will provide sufficient resolution to maintain the specified measurement accuracy of the TMP03/TMP03L. While a system running a 1 MHz clock will require counter registers of at least 12 bits, faster clocks will require commensurately larger registers to avoid overflow truncation errors. See the Applications section below which discusses a variety of hardware interfacing and software ideas.

## Self-Heating Effects

Observing the thermal conductivity of the various TMP03/ TMP03L packages, in some applications the user should consider the effects of self-heating due to the power dissipated by the digital output, which is capable of sinking $800 \mu \mathrm{~A}$ continuous. Under full load, the output may dissipate

$$
P_{D I S S}=(0.6 \mathrm{~V})(0.8 \mathrm{~mA})=0.48 \mathrm{~mW}
$$

which in a free-standing surface-mount TSSOP package accounts for a temperature increase due to self-heating of

$$
\Delta T=P_{D I S S} \times \theta_{y A}=0.48 \mathrm{~mW} \times X X X^{\circ} \mathrm{C} / W=Y Y^{\circ} \mathrm{C} .
$$

This will, of course, directly affect the accuracy of the TMP03/ TMP03L relative to the true ambient temperature. Alternatively, when the same package has been bonded to measure a large plate or other thermal mass (effectively a large heatsink), the self-heating error might be limited to approximately

$$
\Delta T=P_{D I S S} \times \theta_{y C}=0.48 \mathrm{~mW} \times 10^{\circ} \mathrm{C} / \mathrm{W}=0.0048^{\circ} \mathrm{C}
$$

which is a negligible error.

## Signal Compression Components Contents

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Selection Tree - Signal Compression Components


## Selection Guide－Signal Compression Components

| Model | Input <br> Range | Log <br> Conformity RTI | $\begin{aligned} & \text { BW } \\ & \text { kHz } \end{aligned}$ | Package Options ${ }^{1}$ | Temp Ranges ${ }^{2}$ | Comments | Page |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| AD640 | $0.75 \mathrm{mV}-200 \mathrm{mV}$ | $\pm 0.6 \mathrm{~dB}$ | 120 MHz | D，E，N，P | C， $\mathbf{I}, \mathrm{M} /{ }_{\text {ds }}$ | $120 \mathrm{MHz}, 45 \mathrm{~dB}$ ，DC Demodulating Logarithmic Amplifier | 20－40 |
| AD600 | $\pm 2 \mathrm{~V}$ | $\pm 0.5 \mathrm{~dB}$ | 30 MHz | N， $\mathbf{R}$ | C，I，M／ | Dual 0 dB to＋ 40 dB Variable Gain Amplifier | 20－5 |
| AD602 | $\pm 2 \mathrm{~V}$ | $\pm 0.5 \mathrm{~dB}$ | 30 MHz | N，R | C，I，M／ | Dual－10 dB to＋30 dB Variable Gain Amplifier | 20－5 |
| AD603 | $\pm 2 \mathrm{~V}$ | $\pm 0.4 \mathrm{~dB}$ | 100 MHz | N，R | I，M | Single Channel Variable Gain Amplifier | 20－17 |
| AD606 | $\mathbf{- 8 0}$ to $+10 \mathrm{dBm}(50 \Omega)$ | $\pm 1 \mathrm{~dB}$ | 50 MHz | N，R | C | $50 \mathrm{MHz}, 80 \mathrm{~dB}$ Demodulating Logarithmic Amplifier with Limiter Output | 20－29 |




 temperature designator will be followed by：／to indicate $883 \mathrm{~B},{ }_{J}$ for JAN，${ }_{\mathrm{D}}$ for SMD，and ${ }_{\mathrm{S}}$ for space level．
Boldface Type：Data sheet information in this volume．

Dual, Low Noise, Wideband Variable Gain Amplifiers AD600/AD602*

## FEATURES

Two Channels with Independent Gain Control "Linear in dB" Gain Response
Two Gain Ranges:
AD600: 0 dB to $\mathbf{+ 4 0 ~ d B}$
AD602: $\mathbf{- 1 0} \mathrm{dB}$ to $\mathbf{+ 3 0} \mathrm{dB}$
Accurate Absolute Gain: $\pm \mathbf{0 . 3} \mathbf{~ d B}$
Low Input Noise: $1.4 \mathrm{nV} / \sqrt{\mathrm{Hz}}$
Low Distortion: -60 dBc THD at $\pm 1 \mathrm{~V}$ Output
High Bandwidth: DC to $35 \mathrm{MHz}(-3 \mathrm{~dB})$
Stable Group Delay: $\pm \mathbf{2 n s}$
Low Power: 125 mW (max) per Amplifier
Signal Gating Function for Each Amplifier
Drives High Speed A/D Converters
MIL-STD-883 Compliant and DESC Versions Available
APPLICATIONS

## Ultrasound and Sonar Time-Gain Control High Performance Audio and RF AGC Systems Signal Measurement

## PRODUCT DESCRIPTION

The AD600 and AD602 dual channel, low noise variable gain amplifiers are optimized for use in ultrasound imaging systems, but are applicable to any application requiring very precise gain, low noise and distortion, and wide bandwidth. Each independent channel provides a gain of 0 to +40 dB in the AD600 and -10 dB to +30 dB in the AD602. The lower gain of the AD602 results in an improved signal-to-noise ratio at the output. However, both products have the same $1.4 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ input noise spectral density. The decibel gain is directly proportional to the control voltage, is accurately calibrated, and is supply- and temperature-stable.

To achieve the difficult performance objectives, a proprietary circuit form -the X-AMP ${ }^{\text {TX }}$ - has been developed. Each channel of the X-AMP comprises a variable attenuator of 0 dB to -42.14 dB followed by a high speed fixed gain amplifier. In this way, the amplifier never has to cope with large inputs, and can benefit from the use of negative feedback to precisely define the gain and dynamics. The attenuator is realized as a seven-stage R-2R ladder network having an input resistance of $100 \Omega$, lasertrimmed to $\pm 2 \%$. The attenuation between tap points is 6.02 dB ; the gain-control circuit provides continuous interpolation between these taps. The resulting control function is linear in dB .

X-AMP is a trademark of Analog Devices, Inc.
*Patented.

## FUNCTIONAL BLOCK DIAGRAM



The gain-control interfaces are fully differential, providing an input resistance of $\sim 15 \mathrm{M} \Omega$ and a scale factor of $32 \mathrm{~dB} / \mathrm{V}$ (that is, $31.25 \mathrm{mV} / \mathrm{dB}$ ) defined by an internal voltage reference. The response time of this interface is less than $1 \mu \mathrm{~s}$. Each channel also has an independent gating facility that optionally blocks signal transmission and sets the dc output level to within a few millivolts of the output ground. The gating control input is TTL and CMOS compatible.
The maximum gain of the AD600 is 41.07 dB , and that of the AD602 is 31.07 dB ; the -3 dB bandwidth of both models is nominally 35 MHz , essentially independent of the gain. The signal-to-noise ratio (SNR) for a 1 V rms output and a 1 MHz noise bandwidth is typically 76 dB for the AD600 and 86 dB for the AD602. The amplitude response is flat within $\pm 0.5 \mathrm{~dB}$ from 100 kHz to 10 MHz ; over this frequency range the group delay varies by less than $\pm 2$ ns at all gain settings.
Each amplifier channel can drive $100 \Omega$ load impedances with low distortion. For example, the peak specified output is $\pm 2.5 \mathrm{~V}$ minimum into a $500 \Omega$ load, or $\pm 1 \mathrm{~V}$ into a $100 \Omega$ load. For a $200 \Omega$ load in shunt with 5 pF , the total harmonic distortion for a $\pm 1 \mathrm{~V}$ sinusoidal output at 10 MHz is typically -60 dBc .
The AD600J and AD602J are specified for operation from $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$, and are available in both 16 -pin plastic DIP (N) and 16-pin SOIC (R). The AD600A and AD602A are specified for operation from $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ and are available in both 16 -pin Cerdip (Q) and 16-pin SOIC (R).

The AD600S and AD602S are specified for operation from $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ and are available in a 16-pin Cerdip (Q) package and are MIL-STD-883 compliant. The AD600S and AD602S are also available under DESC SMD 5962-94572.

[^265] noted. Specifications for AD600 and AD602 are identical unless otherwise noted.)

| Parameter | Conditions | AD600J/AD602J |  |  | AD600A/AD602A |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max | Min | Typ | Max |  |
| INPUT CHARACTERISTICS |  |  |  |  |  |  |  |  |
| Input Resistance | Pins 2 to 3; Pins 6 to 7 | 98 | 100 | 102 | 95 | 100 | 105 | $\Omega$ |
| Input Capacitance |  |  | 2 |  |  | 2 |  |  |
| Input Noise Spectral Density ${ }^{1}$ |  |  | 1.4 |  |  | 1.4 |  | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| Noise Figure | $\mathrm{R}_{\mathbf{S}}=50 \Omega$, Maximum Gain |  | 5.3 |  |  | 5.3 |  | dB |
|  | $\mathrm{R}_{\text {s }}=200 \Omega$, Maximum Gain |  | 2 |  |  | 2 |  | dB |
| Common-Mode Rejection Ratio | $\mathrm{f}=100 \mathrm{kHz}$ |  | 30 |  |  | 30 |  | dB |
| OUTPUT CHARACTERISTICS |  |  |  |  |  |  |  |  |
| -3 dB Bandwidth | $\mathrm{V}_{\text {OUT }}=100 \mathrm{mV} \mathrm{rms}$ |  | 35 |  |  | 35 |  | MHz |
| Slew Rate |  |  | 275 |  |  | 275 |  | V/us |
| Peak Output ${ }^{2}$ | $\mathrm{R}_{\mathrm{L}} \geq 500 \Omega$. | $\pm 2.5$ | $\pm 3$ |  | $\pm 2.5$ | $\pm 3$ |  |  |
| Output Impedance | $\mathrm{f} \leq 10 \mathrm{MHz}$ |  | 2 |  |  | 2 |  |  |
| Output Short-Circuit Current |  |  | 50 |  |  | 50 |  | mA |
| Group Delay Change vs. Gain | $\mathrm{f}=3 \mathrm{MHz}$; Full Gain Range |  | $\pm 2$ |  |  | $\pm 2$ |  | ns |
| Group Delay Change vs. Frequency | $\mathrm{V}_{\mathrm{G}}=0 \mathrm{~V} ; \mathrm{f}=1 \mathrm{MHz}$ to 10 MHz |  | $\pm 2$ |  |  | $\pm 2$ |  | ns |
| Total Harmonic Distortion | $\mathrm{R}_{\mathrm{L}}=200 \Omega, \mathrm{~V}_{\text {OUT }}= \pm 1 \mathrm{~V}$ peak, $\mathrm{Rpd}=1 \mathrm{k} \Omega$ |  | -60 |  |  | -60 |  | dBc |
| ACCURACY |  |  |  |  |  |  |  |  |
| AD600 |  |  |  |  |  |  |  |  |
| Gain Error | 0 dB to 3 dB Gain | 0 | +0.5 | +1 | -0.5 | +0.5 | +0.5 | dB |
|  | 3 dB to 37 dB Gain | -0.5 | $\pm 0.2$ | +0.5 | -0.1 | $\pm 0.2$ | +1.0 | dB |
|  | 37 dB to 40 dB Gain | -1 | -0.5 | 0 | -1.5 | -0.5 | +0.5 | dB |
| Maximum Output Offset Voltage ${ }^{3}$ | $\mathrm{V}_{\mathrm{G}}=-625 \mathrm{mV}$ to +625 mV |  | 10 | 50 |  | 10 | 65 | mV |
| Output Offset Variation | $\mathrm{V}_{\mathrm{G}}=-625 \mathrm{mV}$ to +625 mV |  | 10 | 50 |  | 10 | 65 | mV |
| AD602 |  |  |  |  |  |  |  |  |
| Gain Error | -10 dB to -7 dB Gain | 0 | 0.5 | +1 | -0.5 | 0.5 | +1.5 | dB |
|  | -7 dB to 27 dB Gain | -0.5 | $\pm 0.2$ | +0.5 | -1.0 | $\pm 0.2$ | +1.0 | dB |
|  | 27 dB to 30 dB Gain | -1 | -0.5 | 0 | -1.5 | -0.5 | +0.5 | dB |
| Maximum Output Offset Voltage ${ }^{3}$ | $\mathrm{V}_{\mathrm{G}}=-625 \mathrm{mV}$ to +625 mV |  | 5 | 30 |  | 10 | 45 | mV |
| Output Offset Variation | $\mathrm{V}_{\mathrm{G}}=-625 \mathrm{mV}$ to +625 mV |  | 5 | 30 |  | 10 | 45 | mV |
| GAIN CONTROL INTERFACE |  |  |  |  |  |  |  |  |
| Gain Scaling Factor | 3 dB to 37 dB (AD600); -7 dB to 27 dB (AD602) | 31.7 | 32 | 32.3 | 30.5 | 32 | 33.5 | $\mathrm{dB} / \mathrm{V}$ |
| Common-Mode Range |  | -0.75 |  | 2.5 | -0.75 |  | 2.5 |  |
| Input Bias Current |  |  | 0.35 | 1 |  | 0.35 | 1 | $\mu \mathrm{A}$ |
| Input Offset Current |  |  | 10 | 50 |  | 10 | 50 | nA |
| Differential Input Resistance | Pins 1 to 16; Pins 8 to 9 |  | 15 |  |  | 15 |  | $\mathrm{M} \Omega$ |
| Response Rate . | Full 40 dB Gain Change |  | 40 |  |  | 40 |  | $\mathrm{dB} / \mu \mathrm{s}$ |
| SIGNAL GATING INTERFACE |  |  |  |  |  |  |  |  |
| Logic Input "LO" (Output ON) |  |  |  | 0.8 |  |  | 0.8 | V |
| Logic Input "HI" (Output OFF) |  | 2.4 |  |  | 2.4 |  |  | V |
| Response Time | ON to OFF, OFF to ON |  | 0.3 |  |  | 0.3 |  | us |
| Input Resistance | Pins 4 to 3; Pins 5 to 6 |  | 30 |  |  | 30 |  | k $\Omega$ |
| Output Gated OFF |  |  |  |  |  |  |  |  |
| Output Offset Voltage | . |  | $\pm 10$ | $\pm 100$ |  | $\pm 10$ | $\pm 400$ | mV |
|  |  |  | 65 |  |  | 65 |  | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
|  | Signal Feedthrough @ 1 MHz |  |  |  |  |  |  |  |
| AD600 |  | , | -80 |  |  | -80 |  | dB |
| AD602 |  |  | -70 |  |  | -70 |  | dB |
| POWER SUPPLY |  |  |  |  |  |  |  |  |
| Specified Operating Range |  | $\pm 4.75$ |  | $\pm 5.25$ | $\pm 4.75$ |  | $\pm 5.25$ | V |
| Quiescent Current |  |  | 11 | $12.5$ |  | 11 | 14 | mA |

## NOTES

${ }^{1}$ Typical open or short-circuited input; noise is lower when system is set to maximum gain and input is short-circuited. This figure includes the effects of both voltage and current noise sources.
${ }^{2}$ Using resistive loads of $500 \Omega$ or greater, or with the addition of a $1 \mathrm{k} \Omega$ pull-down resistor when driving lower loads.
${ }^{3}$ The dc gain of the main amplifier in the AD600 is X113; thus an input offset of only $100 \mu \mathrm{~V}$ becomes an 11.3 mV output offset. In the AD602, the amplifier's gain is X35.7; thus, an input offset of $100 \mu \mathrm{~V}$ becomes a 3.57 mV output offset.
Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.
Specifications subject to change without notice.


ORDERING GUIDE

| Model | Gain Range | Temperature <br> Range | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD600AQ | 0 dB to +40 dB | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| AD600AR | 0 dB to +40 dB | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16$ |
| AD602AQ | -10 dB to +30 dB | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| AD602AR | -10 dB to +30 dB | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\mathrm{R}-16$ |
| AD600JN | 0 dB to +40 dB | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| AD600JR | 0 dB to +40 dB | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{R}-16$ |
| AD602JN | -10 dB to +30 dB | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{N}-16$ |
| AD602JR | -10 dB to +30 dB | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $\mathrm{R}-16$ |
| AD600SQ $/ 883 \mathrm{~B}^{2}$ | 0 dB to +40 dB | $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |
| AD602SQ $/ 883 \mathrm{~B}^{3}$ | -10 dB to +30 dB | $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ | $\mathrm{Q}-16$ |

NOTES
${ }^{1} \mathrm{~N}=$ Plastic DIP; $\mathrm{Q}=$ Cerdip; $\mathrm{R}=$ Small Outline IC (SOIC). For outline information see Package Information section.
${ }^{2}$ Refer to AD600/AD602 Military data sheet. Also available as $5962-9457201 \mathrm{MPA}$.
${ }^{3}$ Refer to AD600/AD602 Military data sheet. Also available as $5962-9457202 \mathrm{MPA}$.

## CAUTION

ESD (electrostatic discharge) sensitive device. Permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are removed.

## PIN DESCRIPTIONS

| Pin | Function | Description |
| :---: | :---: | :---: |
| Pin 1 | ClLO | CH1 Gain-Control Input "LO" (Positive Voltage Reduces CH1 Gain). |
| Pin 2 | AlHI | CH1 Signal Input "HI" (Positive Voltage Increases CH1 Output). |
| Pin 3 | AlLO | CH1 Signal Input "LO" (Usually Taken to CH1 Input Ground). |
| Pin 4 | GAT1 | CH1 Gating Input (A Logic "HI" Shuts Off CH1 Signal Path). |
| Pin 5 | GAT2 | CH2 Gating Input (A Logic "HI" Shuts Off CH2 Signal Path). |
| Pin 6 | A2LO | CH2 Signal Input "LO" (Usually Taken to CH2 Input Ground). |
| Pin 7 | A2HI | CH 2 Signal Input "HI" (Positive Voltage Increases CH2 Output). |
| Pin 8 | C2LO | CH2 Gain-Control Input "LO" (Positive Voltage Reduces CH2 Gain). |
| Pin 9 | C2HI | CH 2 Gain-Control Input "HI" (Positive Voltage Increases CH2 Gain). |
| Pin 10 | A2CM | CH 2 Common (Usually Taken to CH2 Output Ground). |
| Pin 11 | A2OP | CH2 Output. |
| Pin 12 | VNEG | Negative Supply for Both Amplifiers. |
| Pin 13 | VPOS | Positive Supply for Both Amplifiers. |
| Pin 14 | A1OP | CH1 Output. |
| Pin 15 | AlCM | CH1 Common (Usually Taken to CH1 Output Ground). |
| Pin 16 | ClHI | CH1 Gain-Control Input "HI" (Positive Voltage Increases CH1 Gain). |

## CONNECTION DIAGRAM

16-Pin Plastic DIP (N) Package 16-Pin Plastic SOIC (R) Package 16-Pin Cerdip (Q) Package


## AD600/AD602

## THEORY OF OPERATION

The AD600 and AD602 have the same general design and features. They comprise two fixed gain amplifiers, each preceded by a voltage-controlled attenuator of 0 dB to 42.14 dB with independent control interfaces, each having a scaling factor of 32 dB per volt. The gain of each amplifier in the AD600 is laser trimmed to $41.07 \mathrm{~dB}(\mathrm{X} 113)$, thus providing a control range of -1.07 dB to $41.07 \mathrm{~dB}(0 \mathrm{~dB}$ to 40 dB with overlap), while the AD602 amplifiers have a gain of 31.07 dB (X35.8) and provide an overall gain of -11.07 dB to $31.07 \mathrm{~dB}(-10 \mathrm{~dB}$ to 30 dB with overlap).
The advantage of this topology is that the amplifier can use negative feedback to increase the accuracy of its gain; also, since the amplifier never has to handle large signals at its input, the distortion can be very low. A further feature of this approach is that the small-signal gain and phase response, and thus the pulse response, are essentially independent of gain.
The following discussion describes the AD600. Figure 1 is a simplified schematic of one channel. The input attenuator is a seven-section R-2R ladder network, using untrimmed resistors of nominally $R=62.5 \Omega$, which results in a characteristic resistance of $125 \Omega \pm 20 \%$. A shunt resistor is included at the input and laser trimmed to establish a more exact input resistance of $100 \Omega \pm 2 \%$, which ensures accurate operation (gain and HP corner frequency) when used in conjunction with external resistors or capacitors.


Figure 1. Simplified Block Diagram of Single Channel of the AD600 and AD602

The nominal maximum signal at input A1HI is 1 V rms ( $\pm 1.4 \mathrm{~V}$ peak) when using the recommended $\pm 5 \mathrm{~V}$ supplies, although operation to $\pm 2 \mathrm{~V}$ peak is permissible with some increase in HF distortion and feedthrough. Each attenuator is provided with a separate signal "LO" connection, for use in rejecting common-mode, the voltage between input and output grounds. Circuitry is included to provide rejection of up to $\pm 100 \mathrm{mV}$.
The signal applied at the input of the ladder network is attenuated by 6.02 dB by each section; thus, the attenuation to each of the taps is progressively $0,6.02,12.04,18.06,24.08,30.1,36.12$ and 42.14 dB . A unique circuit technique is employed to interpolate between these tap points, indicated by the "slider" in Figure 1, providing continuous attenuation from 0 dB to 42.14 dB .

It will help, in understanding the AD600, to think in terms of a mechanical means for moving this slider from left to right; in fact, it is voltage controlled. The details of the control interface are discussed later. Note that the gain is at all times exactly determined, and a linear decibel relationship is automatically guaranteed between the gain and the control parameter which determines the position of the slider. In practice, the gain deviates from the ideal law, by about $\pm 0.2 \mathrm{~dB}$ peak (see, for example, Figure 6).
Note that the signal inputs are not fully differential: A1LO and A 1 CM (for CH 1 ) and A2LO and A2CM (for CH 2 ) provide separate access to the input and output grounds. This recognizes the practical fact that even when using a ground plane, small differences will arise in the voltages at these nodes. It is important that A1LO and A2LO be connected directly to the input ground(s); significant impedance in these connections will reduce the gain accuracy. A1CM and A2CM should be connected to the load ground(s).

## Noise Performance

An important reason for using this approach is the superior noise performance that can be achieved. The nominal resistance seen at the inner tap points of the attenuator is $41.7 \Omega$ (one third of $125 \Omega$ ), which exhibits a Johnson noise spectral density (NSD) of $0.84 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ (that is, $\sqrt{4 \mathrm{kTR}}$ ) at $27^{\circ} \mathrm{C}$, which is a large fraction of the total input noise. The first stage of the amplifier contributes a further $1.12 \mathrm{nV} / \sqrt{\mathrm{Hz}}$, for a total input noise of $1.4 \mathrm{nV} / \sqrt{\mathrm{Hz}}$.
The noise at the 0 dB tap depends on whether the input is short-circuited or open-circuited: when shorted, the minimum NSD of $1.12 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ is achieved; when open, the resistance of $100 \Omega$ at the first tap generates $1.29 \mathrm{nV} / \sqrt{\mathrm{Hz}}$, so the noise increases to a total of $1.71 \mathrm{nV} / \sqrt{\mathrm{Hz}}$. (This last calculation would be important if the AD600 were preceded, for example, by a $900 \Omega$ resistor to allow operation from inputs up to $\pm 10 \mathrm{~V}$ rms. However, in most cases the low impedance of the source will limit the maximum noise resistance.)
It will be apparent from the foregoing that it is essential to use a low resistance in the design of the ladder network to achieve low noise. In some applications this may be inconvenient, requiring the use of an external buffer or preamplifier. However, very few amplifiers combine the needed low noise with low distortion at maximum input levels, and the power consumption needed to achieve this performance is fundamentally required to be quite high (due to the need to maintain very low resistance values while also coping with large inputs). On the other hand, there is little value in providing a buffer with high input impedance, since the usual reason for this-the minimization of loading of a high resistance source-is not compatible with low noise.
Apart from the small variations just discussed, the signal-tonoise ( $\mathrm{S} / \mathrm{N}$ ) ratio at the output is essentially independent of the attenuator setting, since the maximum undistorted output is 1 V rms and the NSD at the output of the AD600 is fixed at 113 times $1.4 \mathrm{nV} \sqrt{\mathrm{Hz}}$, or $158 \mathrm{nV} / \sqrt{\mathrm{Hz}}$. Thus, in a 1 MHz bandwidth, the output $\mathrm{S} / \mathrm{N}$ ratio would be 76 dB . The input NSD of the AD600 and AD602 are the same, but because of the 10 dB lower gain in the AD602's fixed amplifier, its output $\mathrm{S} / \mathrm{N}$ ratio is 10 dB better, or 86 dB in a 1 MHz bandwidth.

## The Gain-Control Interface

The attenuation is controlled through a differential, high impedance ( $15 \mathrm{M} \Omega$ ) input, with a scaling factor which is laser trimmed to 32 dB per volt, that is, $31.25 \mathrm{mV} / \mathrm{dB}$. Each of the two amplifiers has its own control interface. An internal bandgap reference ensures stability of the scaling with respect to supply and temperature variations, and is the only circuitry common to both channels.

When the differential input voltage $\mathrm{V}_{\mathrm{G}}=0 \mathrm{~V}$, the attenuator "slider" is centered, providing an attenuation of 21.07 dB , thus resulting in an overall gain of $20 \mathrm{~dB}(=-21.07 \mathrm{~dB}+41.07 \mathrm{~dB})$. When the control input is -625 mV , the gain is lowered by $20 \mathrm{~dB}(=0.625 \times 32$ ), to 0 dB ; when set to +625 mV , the gain is increased by 20 dB , to 40 dB . When this interface is overdriven in either direction, the gain approaches either -1.07 dB $(=-42.14 \mathrm{~dB}+41.07 \mathrm{~dB})$ or $41.07 \mathrm{~dB}(=0+41.07 \mathrm{~dB})$, respectively.
The gain of the AD600 can thus be calculated using the following simple expression:

$$
\begin{equation*}
\operatorname{Gain}(d B)=32 V_{G}+20 \tag{1}
\end{equation*}
$$

where $\mathrm{V}_{\mathrm{G}}$ is in volts. For the AD602, the expression is:

$$
\begin{equation*}
\operatorname{Gain}(d B)=32 V_{G}+10 \tag{2}
\end{equation*}
$$

Operation is specified for $V_{G}$ in the range from -625 mV dc to +625 mV dc. The high impedance gain-control input ensures minimal loading when driving many amplifiers in multiplechannel applications. The differential input configuration provides flexibility in choosing the appropriate signal levels and polarities for various control schemes.
For example, the gain-control input can be fed differentially to the inputs, or single-ended by simply grounding the unused input. In another example, if the gain is to be controlled by a DAC providing a positive only ground referenced output, the "Gain Control LO" pin (either C1LO or C2LO) should be biased to a fixed offset of +625 mV , to set the gain to 0 dB when "Gain Control HI" ( C 1 HI or C 2 HI ) is at zero, and to 40 dB when at +1.25 V .
It is a simple matter to include a voltage divider to achieve other scaling factors. When using an 8 -bit DAC having a FS output of $+2.55 \mathrm{~V}(10 \mathrm{mV} / \mathrm{bit})$ a divider ratio of 1.6 (generating $6.25 \mathrm{mV} / \mathrm{bit}$ ) would result in a gain setting resolution of $0.2 \mathrm{~dB} /$ bit. Later, we will discuss how the two sections of an AD600 or AD602 may be cascaded, when various options exist for gain control.

## Signal-Gating Inputs

Each amplifier section of the AD600 and AD602 is equipped with a signal gating function, controlled by a TTL or CMOS logic input (GAT1 or GAT2). The ground references for these inputs are the signal input grounds A1LO and A2LO, respectively. Operation of the channel is unaffected when this input is LO or left open-circuited. Signal transmission is blocked when this input is HI. The dc output level of the channel is set to within a few millivolts of the output ground (A1CM or A2CM), and simultaneously the noise level drops significantly. The reduction in noise and spurious signal feedthrough is useful in ultrasound beam-forming applications, where many amplifier outputs are summed.

## Common-Mode Rejection

A special circuit technique is used to provide rejection of voltages appearing between input grounds (A1LO and A2LO) and output grounds (A1CM and A2CM). This is necessary because of the "op amp" form of the amplifier, as shown in Figure 1. The feedback voltage is developed across the resistor RF1 (which, to achieve low noise, has a value of only $20 \Omega$ ). The voltage developed across this resistor is referenced to the input common, so the output voltage is also referred to that node.
To provide rejection of this common voltage, an auxiliary amplifier (not shown) is included, which senses the voltage difference between input and output commons and cancels this error component. Thus, for zero differential signal input between AlHI and A1LO, the output A1OP simply follows the voltage at A1CM. Note that the range of voltage differences which can exist between A1LO and A1CM (or A2LO and A2CM) is limited to about $\pm 100 \mathrm{mV}$. Figure 50 (one of the typical performance curves at the end of this data sheet) shows typical common-mode rejection ratio versus frequency.

## ACHIEVING 80 dB GAIN RANGE

The two amplifier sections of the X-AMP can be connected in series to achieve higher gain. In this mode, the output of A1 (A1OP and A1CM) drives the input of A2 via a high-pass network (usually just a capacitor) that rejects the dc offset. The nominal gain range is now -2 dB to +82 dB for the AD600 or -22 dB to +62 dB for the AD602.

There are several options in connecting the gain-control inputs. The choice depends on the desired signal-to-noise ratio (SNR) and gain error (output ripple). The following examples feature the AD600; the arguments generally apply to the AD602, with appropriate changes to the gain values.

## Sequential Mode (Maximum S/N Ratio)

In the sequential mode of operation, the SNR is maintained at its highest level for as much of the gain control range possible, as shown in Figure 2. Note here that the gain range is 0 dB to 80 dB . Figure 3 shows the general connections to accomplish this. Both gain-control inputs, C 1 HI and C 2 HI , are driven in parallel by a positive only, ground referenced source with a range of 0 V to +2.5 V .


Figure 2. $S / N$ Ratio vs. Control Voltage Sequential Control (1 MHz Bandwidth)


Figure 3. AD600 Gain Control Input Calculations for Sequential Control Operation

The gains are offset (Figure 4) such that A2's gain is increased only after Al's gain has reached its maximum value. Note that for a differential input of -700 mV or less, the gain of a single amplifier (A1 or A2) will be at its minimum value of -1.07 dB ; for a differential input of +700 mV or more, the gain will be at its maximum value of 41.07 dB . Control inputs beyond these limits will not affect the gain and can be tolerated without damage or foldover in the response. See the Specifications Section of this data sheet for more details on the allowable voltage range. The gain is now
$\operatorname{Gain}(d B)=32 V_{C}$
where $\mathrm{V}_{\mathrm{C}}$ is the applied control voltage.


Figure 4. Explanation of Offset Calibration for Sequential Control

When $\mathrm{V}_{\mathrm{C}}$ is set to zero, $\mathrm{V}_{\mathrm{G} 1}=-0.592 \mathrm{~V}$ and the gain of A 1 is +1.07 dB (recall that the gain of each amplifier section is 0 dB for $\mathrm{V}_{\mathrm{G}}=-625 \mathrm{mV}$ ); meanwhile, $\mathrm{V}_{\mathrm{G} 2}=-1.908 \mathrm{~V}$ so the gain of A 2 is -1.07 dB . The overall gain is thus 0 dB (see Figure 3a). When $\mathrm{V}_{\mathrm{C}}=+1.25 \mathrm{~V}, \mathrm{~V}_{\mathrm{Gl}}=1.25 \mathrm{~V}-0.592 \mathrm{~V}=$ +0.658 V , which sets the gain of A1 to 40.56 dB , while $\mathrm{V}_{\mathrm{G} 2}=1.25 \mathrm{~V}-1.908 \mathrm{~V}=-0.658 \mathrm{~V}$, which sets A2's gain at -0.56 dB . The overall gain is now 40 dB (see Figure 3 b ). When $\mathrm{V}_{\mathrm{C}}=+2.5 \mathrm{~V}$, the gain of A 1 is 41.07 dB and that of A 2 is 38.93 dB , resulting in an overall gain of 80 dB (see Figure 3c).

This mode of operation is further clarified by Figure 5, which is a plot of the separate gains of A1 and A2 and the overall gain versus the control voltage. Figure 6 is a plot of the gain error of the cascaded amplifiers versus the control voltage.
Parallel Mode (Simplest Gain-Control Interface)
In this mode, the gain-control voltage is applied to both inputs in parallel - C 1 HI and C 2 HI are connected to the control voltage, and C1LO and C2LO are optionally connected to an offset voltage of +0.625 V . The gain scaling is then doubled to $64 \mathrm{~dB} /$ V , requiring only 1.25 V for an 80 dB change of gain. The amplitude of the gain ripple in this case is also doubled, as shown in Figure 7, and the instantaneous signal-to-noise ratio at the output of A2 decreases linearly as the gain is increased (Figure 8).

## Low Ripple Mode (Minimum Gain Error)

As can be seen in Figures 6 and 7, the output ripple is periodic. By offsetting the gains of A1 and A2 by half the period of the ripple, or 3 dB , the residual gain errors of the two amplifiers can be made to cancel. Figure 9 shows the much lower gain ripple when configured in this manner. Figure 10 plots the $\mathrm{S} / \mathrm{N}$ ratio as a function of gain; it is very similar to that in the "Parallel Mode."


Figure 5. Plot of Separate and Overall Gains in Sequential Control


Figure 6. Gain Error for Cascaded Stages-Sequential Control


Figure 7. Gain Error for Cascaded Stages - Parallel Control


Figure 8. SNR for Cascaded Stages - Parallel Control


Figure 9. Gain Error for Cascaded Stages-Low Ripple Mode


Figure 10. ISNR vs. Control Voltage-Low Ripple Mode

## APPLICATIONS

The full potential of any high performance amplifier can only be realized by careful attention to details in its applications. The following pages describe fully tested circuits in which many such details have already been considered. However, as is always true of high accuracy, high speed analog circuits, the schematic is only part of the story; this is no less true for the AD600 and AD602. Appropriate choices in the overall board layout and the type and placement of power supply decoupling components are very important. As explained previously, the input grounds A1LO and A2LO must use the shortest possible connections.
The following circuits show examples of time-gain control for ultrasound and for sonar, methods for increasing the output drive, and AGC amplifiers for audio and RF/IF signal processing using both peak and rms detectors. These circuits also illustrate methods of cascading X-AMPs for either maintaining the optimal $\mathrm{S} / \mathrm{N}$ ratio or maximizing the accuracy of the gain-control voltage for use in signal measurement. These AGC circuits may be modified for use as voltage-controlled amplifiers for use in sonar and ultrasound applications by removing the detector and substituting a DAC or other voltage source for supplying the control voltage.
Time-Gain Control (TGC) and Time-Variable Gain (TVG) Ultrasound and sonar systems share a similar requirement: both need to provide an exponential increase in gain in response to a linear control voltage, that is, a gain control that is "linear in dB." Figure 11 shows the AD600/AD602 configured for a control voltage ramp starting at -625 mV and ending at +625 mV for a gain-control range of 40 dB . For simplicity, only the A1 connections are shown. The polarity of the gain-control voltage may be reversed and the control voltage inputs C 1 HI and C1LO reversed to achieve the same effect. The gain-control voltage can be supplied by a voltage-output DAC such as the AD7242, which contains two complete DACs, operates from $\pm 5 \mathrm{~V}$ supplies, has an internal reference of 3 V , and provides $\pm 3 \mathrm{~V}$ of output swing. As such it is well-suited for use with the AD600/ AD602, needing only a few resistors to scale the output voltage of the DACs to the levels needed by the AD600/AD602.


Figure 11. The Simplest Application of the X-AMP is as a TGC or TVG Amplifier in Ultrasound or Sonar. Only the A1 Connections Are Shown for Simplicity.

## Increasing Output Drive

The AD600/AD602's output stage has limited capability for negative-load driving capability. For driving loads less than $500 \Omega$, the load drive may be increased by about 5 mA by connecting a $1 \mathrm{k} \Omega$ pull-down resistor from the output to the negative supply (Figure 12).

## Driving Capacitive Loads

For driving capacitive loads of greater than 5 pF , insert a $10 \Omega$ resistor between the output and the load. This lowers the possibility of oscillation.


Figure 12. Adding a $1 \mathrm{k} \Omega$ Pull-Down Resistor Increases the X-AMP's Output Drive by About 5 mA . Only the A1 Connections Are Shown for Simplicity.

## Realizing Other Gain Ranges

Larger gain ranges can be accommodated by cascading amplifiers. Combinations built by cascading two amplifiers include -20 dB to +60 dB (using one AD602), -10 dB to $+70 \mathrm{~dB}(1 / 2$ of an AD602 followed by $1 / 2$ of an AD600), and 0 dB to 80 dB (one AD600). In multiple-channel applications, extra protection against oscillations can be provided by using amplifier sections from different packages.

## An Ultralow Noise VCA

The two channels of the AD600 or AD602 may be operated in parallel to achieve a 3 dB improvement in noise level, providing $1 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ without any loss of gain accuracy or bandwidth.
In the simplest case, as shown in Figure 13, the signal inputs A 1 HI and A 2 HI are tied directly together, the outputs A1OP and A2OP are summed via R1 and R2 ( $100 \Omega$ each), and the control inputs $\mathrm{C} 1 \mathrm{HI} / \mathrm{C} 2 \mathrm{HI}$ and $\mathrm{C} 1 \mathrm{LO} / \mathrm{C} 2 \mathrm{LO}$ operate in parallel. Using these connections, both the input and output resistances are $50 \Omega$. Thus, when driven from a $50 \Omega$ source and terminated in a $50 \Omega$ load, the gain is reduced by 12 dB , so the gain range becomes -12 dB to +28 dB for the AD600 and -22 dB to +18 dB for the AD602. The peak input capability remains unaffected ( 1 V rms at the IC pins, or 2 V rms from an unloaded $50 \Omega$ source). The loading on each output, with a $50 \Omega$ load, is effectively $200 \Omega$, because the load current is shared between the two channels, so the overall amplifier still meets its specified maximum output and distortion levels for a $200 \Omega$ load. This amplifier can deliver a maximum sine wave power of +10 dBm to the load.


Figure 13. An Ultralow Noise VCA Using the AD600 or AD602

## A Low Noise, 6 dB Preamplifier

In some ultrasound applications, the user may wish to use a high input impedance preamplifier to avoid the signal attenuation that would result from loading the transducer by the $100 \Omega$ input resistance of the X-AMP. High gain cannot be tolerated, because the peak transducer signal is typically $\pm 0.5 \mathrm{~V}$, while the peak input capability of the AD600 or AD602 is only slightly more than $\pm 1 \mathrm{~V}$. A gain of two is a suitable choice. It can be shown that if the preamplifier's overall referred-to-input (RTI) noise is to be the same as that due to the X-AMP alone $(1.4 \mathrm{nV} /$ $\sqrt{\mathrm{Hz}})$, then the input noise of a X 2 preamplifier must be $\sqrt{(3 /}$ $\frac{\sqrt{4)}}{}$ times as large, that is, $1.2 \mathrm{nV} / \sqrt{\mathrm{Hz}}$.


Figure 14. A Low Noise Preamplifier for the AD600 and AD602

An inexpensive circuit, using complementary transistor types chosen for their low $\mathrm{r}_{\mathrm{bb}^{\prime}}$, is shown in Figure 14. The gain is determined by the ratio of the net collector load resistance to the net emitter resistance, that is, it is an open-loop amplifier. The gain will be $\mathrm{X} 2(6 \mathrm{~dB})$ only into a $100 \Omega$ load, assumed to be provided by the input resistance of the X-AMP; R2 and R7 are in shunt with this load, and their value is important in defining the gain. For small-signal inputs, both transistors contribute an equal transconductance, which is rendered less sensitive to signal level by the emitter resistors R4 and R5, which also play a dominant role in setting the gain.
This is a Class AB amplifier. As $\mathrm{V}_{\mathrm{IN}}$ increases in a positive direction, Q1 conducts more heavily and its $r_{e}$ becomes lower while that of Q2 increases. Conversely, more negative values of $V_{\text {IN }}$ result in the $r_{e}$ of Q2 decreasing, while that of Q1 increases. The design is chosen such that the net emitter resistance is essentially independent of the instantaneous value of $\mathrm{V}_{\mathrm{IN}}$, resulting in moderately low distortion. Low values of resistance and moderately high bias currents are important in achieving the low noise, wide bandwidth, and low distortion of this preamplifier. Heavy decoupling prevents noise on the power supply lines from being conveyed to the input of the X-AMP.

Table I. Measured Preamplifier Performance

| Measurement |  | Value | Units |
| :---: | :---: | :---: | :---: |
| Gain ( $\mathrm{f}=30 \mathrm{MHz}$ ) |  | 6 | dB |
| Bandwidth ( -3 dB ) |  | 250 | MHz |
| Input Signal for |  | 1 | V p-p |
| Distortion |  |  |  |
| $\mathrm{V}_{\text {IN }}=200 \mathrm{mV}$ p-p | HD2 | 0.27 | \% |
|  | HD3 | 0.14 | \% |
| $\mathrm{V}_{\text {IN }}=500 \mathrm{mV}$ p-p | HD2 | 0.44 | \% |
|  | HD3 | 0.58 | \% |
| System Input Noise Spectral Density (NSD) (Preamp plus X-AMP) |  | 1.03 | $\mathrm{nV} / \sqrt{ } \overline{\mathrm{Hz}}$ |
|  |  |  |  |
| Input Resistance |  | 1.4 | $\mathrm{k} \Omega$ |
| Input Capacitance |  | 15 | pF |
| Input Bias Current |  | $\pm 150$ | $\mu \mathrm{A}$ |
| Power Supply Voltage |  | $\pm 5$ | V |
| Quiescent Current |  | 15 | mA |

## A Low Noise AGC Amplifier with $\mathbf{8 0} \mathbf{d B}$ Gain Range

Figure 15 provides an example of the ease with which the AD600 can be connected as an AGC amplifier. A1 and A2 are cascaded, with 6 dB of attenuation introduced by the $100 \Omega$ resistor R 1 , while a time constant of 5 ns is formed by Cl and the $50 \Omega$ of net resistance at the input of A2. This has the dual effect of (a) lowering the overall gain range from $\{0 \mathrm{~dB}$ to $80 \mathrm{~dB}\}$ to $\{6 \mathrm{~dB}$ to 74 dB$\}$ and (b) introducing a single-pole lowpass filter with a -3 dB frequency of about 32 MHz . This ensures stability at the maximum gain for a slight reduction in the overall bandwidth. The capacitor C4 blocks the small dc offset voltage at the output of A1 (which might otherwise saturate A 2 at its maximum gain) and introduces a high pass corner at about 8 kHz , useful in eliminating low frequency noise and spurious signals which may be present at the input.


Figure 15. This Accurate HF AGC Amplifier Uses Just Three Active Components.

A simple half-wave detector is used, based on Q1 and R2. The average current into capacitor C 2 is just the difference between the current provided by the AD590 ( $300 \mu \mathrm{~A}$ at $300 \mathrm{~K}, 27^{\circ} \mathrm{C}$ ) and the collector current of Q 1 . In turn, the control voltage $\mathrm{V}_{\mathrm{G}}$ is the time integral of this error current. When $\mathrm{V}_{\mathrm{G}}$ (and thus the gain) is stable, the rectified current in Q1 must, on average, exactly balance the current in the AD590. If the output of A2 is too small to do this, $\mathrm{V}_{\mathrm{G}}$ will ramp up, causing the gain to increase, until Q1 conducts sufficiently. The operation of this control system will now be described in detail.
First, consider the particular case where R2 is zero and the output voltage $\mathrm{V}_{\text {OUT }}$ is a square wave at, say, 100 kHz , that is, well above the corner frequency of the control loop. During the time $\mathrm{V}_{\text {OUT }}$ is negative, Q 1 conducts; when $\mathrm{V}_{\text {OUT }}$ is positive, it is cut off. Since the average collector current is forced to be $300 \mu \mathrm{~A}$, and the square wave has a $50 \%$ duty-cycle, the current when conducting must be $600 \mu \mathrm{~A}$. With R2 omitted, the peak value of $\mathrm{V}_{\mathrm{OUT}}$ would be just the $\mathrm{V}_{\mathrm{BE}}$ of Q 1 at $600 \mu \mathrm{~A}$ (typically about 700 mV ) or $2 \mathrm{~V}_{\mathrm{BE}}$ peak-to-peak. This voltage, hence the amplitude at which the output stabilizes, has a strong negative temperature coefficient (TC), typically $-1.7 \mathrm{mV} /{ }^{\circ} \mathrm{C}$. While this may not be troublesome in some applications, the correct value of R2 will render the output stable with temperature.
To understand this, first note that the current in the AD590 is closely proportional to absolute temperature (PTAT). (In fact, this IC is intended for use as a thermometer.) For the moment, continue to assume that the signal is a square wave. When Q1 is conducting, $\mathrm{V}_{\mathrm{OUT}}$ is the now the sum of $\mathrm{V}_{\mathrm{BE}}$ and a voltage which is PTAT and which can be chosen to have an equal but opposite TC to that of the base-to-emitter voltage. This is actually nothing more than the "bandgap voltage reference" principle in thinly veiled disguise! When we choose R2 such that the sum of the voltage across it and the $\mathrm{V}_{\mathrm{BE}}$ of Q 1 is close to the bandgap voltage of about $1.2 \mathrm{~V}, \mathrm{~V}_{\text {Out }}$ will be stable over a wide range of temperatures, provided, of course, that Q 1 and the AD590 share the same thermal environment.

Since the average emitter current is $600 \mu \mathrm{~A}$ during each halfcycle of the square wave, a resistor of $833 \Omega$ would add a PTAT voltage of 500 mV at 300 K , increasing by $1.66 \mathrm{mV} /{ }^{\circ} \mathrm{C}$. In practice, the optimum value of R2 will depend on the transistor used, and, to a lesser extent, on the waveform for which the temperature stability is to be optimized; for the devices shown and sine wave signals, the recommended value is $806 \Omega$. This resistor also serves to lower the peak current in Q1 and the 200 Hz LP filter it forms with C2 helps to minimize distortion due to ripple in $\mathrm{V}_{\mathrm{G}}$. Note that the output amplitude under sine wave conditions will be higher than for a square wave, since the average value of the current for an ideal rectifier would be 0.637 times as large, causing the output amplitude to be 1.88 ( $=1.2 / 0.637$ ) V, or 1.33 V rms . In practice, the somewhat nonideal rectifier results in the sine wave output being regulated to about 1.275 V rms.

An offset of +375 mV is applied to the inverting gain-control inputs C1LO and C2LO. Thus the nominal -625 mV to +625 mV range for $\mathrm{V}_{\mathrm{G}}$ is translated upwards (at $\mathrm{V}_{\mathrm{G}}{ }^{\prime}$ ) to -0.25 V for minimum gain to +1 V for maximum gain. This prevents Q1 from going into heavy saturation at low gains and leaves sufficient "headroom" of 4 V for the AD590 to operate correctly at high gains when using a +5 V supply.
In fact, the 6 dB interstage attenuator means that the overall gain of this AGC system actually runs from -6 dB to +74 dB . Thus, an input of 2 V rms would be required to produce a 1 V rms output at the minimum gain, which exceeds the 1 V rms maximum input specification of the AD600. The available gain range is therefore 0 dB to 74 dB (or, X1 to X5000). Since the gain scaling is $15.625 \mathrm{mV} / \mathrm{dB}$ (because of the cascaded stages) the minimum value of $\mathrm{V}_{\mathrm{G}}{ }^{\prime}$ is actually increased by $6 \times$ 15.625 mV , or about 94 mV , to -156 mV , so the risk of saturation in Q1 is reduced.
The emitter circuit of Q1 is somewhat inductive (due its finite $f_{t}$ and base resistance). Consequently, the effective value of R2 increases with frequency. This would result in an increase in the stabilized output amplitude at high frequencies, but for the
addition of C 3 , determined experimentally to be 15 pF for the 2N3904 for maximum response flatness. Alternatively, a faster transistor can be used here to reduce HF peaking. Figure 16 shows the ac response at the stabilized output level of about 1.3 V rms. Figure 17 demonstrates the output stabilization for sine wave inputs of 1 mV to 1 V rms at frequencies of 100 kHz , 1 MHz and 10 MHz .


Figure 16. AC Response at the Stabilized Output Level of 1.3 V RMS


Figure 17. Output Stabilization vs. RMS Input for Sine Wave Inputs at $100 \mathrm{kHz}, 1 \mathrm{MHz}$, and 10 MHz

While the "bandgap" principle used here sets the output amplitude to 1.2 V (for the square wave case), the stabilization point can be set to any higher amplitude, up to the maximum output of $\pm\left(V_{s}-2\right) \mathrm{V}$ which the AD600 can support. It is only necessary to split R2 into two components of appropriate ratio whose parallel sum remains close to the zero-TC value of $806 \Omega$. This is illustrated in Figure 18, which shows how the output can be raised, without altering the temperature stability.

## Typical Performance Characteristics



Figure 18. Gain Error vs. Gain Control Voltage


Figure 19. AD600 Frequency and Phase Response vs. Gain


Figure 20. AD602 Frequency and Phase Response vs. Gain

## AD600/AD602-Typical Performance Characteristics



Figure 21. AD600 and AD602 Typical Group Delay vs. $V_{c}$


Figure 24. Input Impedance vs. Frequency


Figure 22. Third Order Intermodulation Distortion, $V_{\text {Out }}=2 V p-p$, $R_{L}=500 \Omega$


Figure 25. Output Offset vs. Gain Control Voltage (Control Channel Feedthrough)


Figure 28. PSRR vs. Frequency


Figure 23. Typical Output Voltage vs. Load Resistance (Negative Output Swing Limits First)


Figure 26. Gain Control Channel Response Time. Top: Output Voltage, 2 V max; Bottom: Gain Control Voltage $V_{C}= \pm 625 \mathrm{mV}$


Figure 29. Crosstalk Between A1 and A2 vs. Frequency

## FEATURES

"Linear in dB" Gain Control
Pin Programmable Gain Ranges
-11 dB to $\mathbf{+ 3 1} \mathrm{dB}$ with 90 MHz Bandwidth +9 dB to +51 dB with 9 MHz Bandwidth
Any Intermediate Range, e.g., $\mathbf{- 1} \mathrm{dB}$ to +41 dB with 45 MHz Bandwidth

## Bandwidth Independent of Variable Gain

$1.3 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ Input Noise Spectral Density $\pm 0.5 \mathrm{~dB}$ Typical Gain Accuracy
MIL-STD-883 Compliant and DESC Versions Available

## APPLICATIONS

RF/IF AGC Amplifier
Video Gain Control
A/D Range Extension
Signal Measurement

## PRODUCT DESCRIPTION

The AD603 is a low noise, voltage-controlled amplifier for use in RF and IF AGC systems. It provides accurate, pin selectable gains of -11 dB to +31 dB with a bandwidth of 90 MHz or +9 dB to +51 dB with a bandwidth of 9 MHz . Any intermediate gain range may be arranged using one external resistor. The input referred noise spectral density is only $1.3 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ and power consumption is 125 mW at the recommended $\pm 5 \mathrm{~V}$ supplies.
The decibel gain is "linear in dB ," accurately calibrated, and stable over temperature and supply. The gain is controlled at a
*Patented.
X-AMP is a trademark of Analog Devices, Inc.
high impedance ( $50 \mathrm{M} \Omega$ ), low bias ( 200 nA ) differential input; the scaling is $25 \mathrm{mV} / \mathrm{dB}$, requiring a gain-control voltage of only 1 V to span the central 40 dB of the gain range. An over- and under-range of 1 dB is provided whatever the selected range. The gain-control response time is less than $1 \mu \mathrm{~s}$ for a 40 dB change.
The differential gain-control interface allows the use of either differential or single-ended positive or negative control voltages. Several of these amplifiers may be cascaded and their gaincontrol gains offset to optimize the system $\mathrm{S} / \mathrm{N}$ ratio.
The AD603 can drive a load impedance as low as $100 \Omega$ with low distortion. For a $500 \Omega$ load in shunt with 5 pF , the total harmonic distortion for a $\pm 1 \mathrm{~V}$ sinusoidal output at 10 MHz is typically -60 dBc . The peak specified output is $\pm 2.5 \mathrm{~V}$ minimum into a $500 \Omega$ load, or $\pm 1 \mathrm{~V}$ into a $100 \Omega$ load.

The AD603 uses a proprietary circuit topology - the X-AMP ${ }^{\text {TM }}$. The X-AMP comprises a variable attenuator of 0 dB to -42.14 dB followed by a fixed-gain amplifier. Because of the attenuator, the amplifier never has to cope with large inputs and can use negative feedback to define its (fixed) gain and dynamic performance. The attenuator has an input resistance of $100 \Omega$, laser trimmed to $\pm 3 \%$, and comprises a seven-stage R-2R ladder network, resulting in an attenuation between tap points of 6.021 dB . A proprietary interpolation technique provides a continuous gain-control function which is linear in dB.

The AD603A is specified for operation from $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ and is available in both 8 -pin SOIC ( R ) and 8-pin ceramic DIP (Q). The AD603S is specified for operation from $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ and is available in an 8 -pin ceramic DIP (Q). The AD603 is also available under DESC SMD 5962-94572.

FUNCTIONAL BLOCK DIAGRAM


AD603-SPECIFICATIONS
(At $T_{A}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{S}}= \pm 5 \mathrm{~V},-500 \mathrm{mV} \leq \mathrm{V}_{\mathrm{G}} \leq+500 \mathrm{mV},-10 \mathrm{~dB}$ to +30 dB Gain Range, $R_{L}=500 \Omega$, and $C_{L}=5 \mathrm{pF}$, unless otherwise noted.)

| Model <br> Parameter | Conditions | Min | $\begin{gathered} \text { AD603 } \\ \text { Typ } \end{gathered}$ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT CHARACTERISTICS <br> Input Resistance <br> Input Capacitance <br> Input Noise Spectral Density ${ }^{1}$ <br> Peak Input Voltage | Pins 3 to 4 <br> Input Short Circuited | 97 | $\begin{aligned} & 100 \\ & 2 \\ & 1.3 \\ & \pm 1.4 \end{aligned}$ | $\begin{aligned} & 103 \\ & \pm 2 \end{aligned}$ | $\begin{aligned} & \Omega \\ & \mathrm{pF} \\ & \mathrm{nV} / \sqrt{\mathrm{Hz}} \\ & \mathrm{~V} \end{aligned}$ |
| OUTPUT CHARACTERISTICS <br> -3 dB Bandwidth <br> Slew Rate <br> Peak Output ${ }^{2}$ <br> Output Impedance <br> Output Short-Circuit Current <br> Group Delay Change vs. Gain <br> Group Delay Change vs. Frequency <br> Differential Gain <br> Differential Phase <br> Total Harmonic Distortion | $\begin{aligned} & \mathrm{V}_{\mathrm{OUT}}=100 \mathrm{mV} \text { rms } \\ & \mathrm{R}_{\mathrm{L}} \geq 500 \Omega \\ & \mathrm{R}_{\mathrm{L}} \geq 500 \Omega \\ & \mathrm{f} \leq 10 \mathrm{MHz} \\ & \mathrm{f}=3 \mathrm{MHz} ; \text { Full Gain Range } \\ & \mathrm{V}_{\mathrm{G}}=0 \mathrm{~V} ; \mathrm{f}=1 \text { to } 10 \mathrm{MHz} \end{aligned}$ $\mathrm{f}=10 \mathrm{MHz}, \mathrm{~V}_{\text {OUT }}=1 \mathrm{~V} \mathrm{rms}$ | $\pm 2.5$ | $\begin{aligned} & 90 \\ & 275 \\ & \pm 3.0 \\ & 2 \\ & 50 \\ & \pm 2 \\ & \pm 2 \\ & 0.2 \\ & 0.2 \\ & -60 \end{aligned}$ |  | MHz <br> V/ $/ \mathrm{s}$ <br> V <br> $\Omega$ <br> mA <br> ns <br> ns <br> \% <br> Degree <br> dBc |
| ACCURACY <br> Gain Accuracy <br> $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ <br> Output Offset Voltage ${ }^{3}$ <br> $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ <br> Output Offset Variation vs. $\mathbf{V}_{\mathbf{G}}$ <br> $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ | $\begin{aligned} & -500 \mathrm{mV} \leq \mathrm{V}_{\mathrm{G}} \leq+500 \mathrm{mV} \\ & \mathrm{~V}_{\mathrm{G}}=0 \mathrm{~V} \\ & -500 \mathrm{mV} \leq \mathrm{V}_{\mathrm{G}} \leq+500 \mathrm{mV} \end{aligned}$ |  | $\pm 0.5$ | $\begin{aligned} & \pm 1 \\ & \pm 1.5 \\ & 20 \\ & 30 \\ & 20 \\ & 30 \end{aligned}$ | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{mV} \\ & \mathrm{mV} \\ & \mathrm{mV} \end{aligned}$ |
| GAIN CONTROL INTERFACE <br> Gain Scaling Factor $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ Common-Mode Range Input Bias Current Input Offset Current Differential Input Resistance Response Rate | Pins 1 to 2 <br> Full 40 dB Gain Change | $\begin{aligned} & 39.4 \\ & 38 \\ & -1.2 \end{aligned}$ | 40 <br> 200 <br> 10 <br> 50 <br> 40 | $\begin{aligned} & 40.6 \\ & 42 \\ & +2.0 \end{aligned}$ | dB/V <br> $\mathrm{dB} / \mathrm{V}$ <br> V <br> nA <br> nA <br> $\mathrm{M} \Omega$ <br> $\mathrm{dB} / \mu \mathrm{s}$ |
| POWER SUPPLY <br> Specified Operating Range <br> Quiescent Current <br> $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |  | $\pm 4.75$ | 12.5 | $\begin{aligned} & \pm 5.25 \\ & 17 \\ & 20 \\ & \hline \end{aligned}$ | V <br> mA <br> mA |

NOTES
${ }^{1}$ Typical open or short-circuited input; noise is lower when system is set to maximum gain and input is short-circuited. This figure includes the effects of both voltage and current noise sources.
${ }^{2}$ Using resistive loads of $500 \Omega$ or greater, or with the addition of a $1 \mathrm{k} \Omega$ pull-down resistor when driving lower loads.
${ }^{3}$ The dc gain of the main amplifier in the AD603 is $\times 35.7$; thus, an input offset of $100 \mu \mathrm{~V}$ becomes a 3.57 mV output offset.
Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.
Specifications subject to change without notice.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD603 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

ABSOLUTE MAXIMUM RATINGS*


PIN DESCRIPTION

| Pin | Mnemonic | Description |
| :--- | :--- | :--- |
| Pin 1 | GPOS | Gain-Control Input "HI" <br> (Positive Voltage Increases Gain) <br> Gain-Control Input "LO" <br> (Negative Voltage Increases Gain) |
| Pin 2 | GNEG | Amplifier Input |
| Pin 3 | VINP | Amplifier Ground |
| Pin 4 | COMM | Connection to Feedback Network |
| Pin 5 | FDBK | Negative Supply Input |
| Pin 6 | VNEG | Amplifier Output |
| Pin 7 | VOUT | Positive Supply Input |

## CONNECTION DIAGRAM

8-Pin Plastic SOIC (R) Package
8-Pin Ceramic DIP (Q) Package


ORDERING GUIDE

| Part Number | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD603AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin SOIC | R-8 |
| AD603AQ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Pin Ceramic DIP | Q-8 |
| AD603SQ $/ 883 \mathrm{~B}^{2}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8 -Pin Ceramic DIP | Q-8 |

NOTES
${ }^{1} \mathrm{R}=$ SOIC; $\mathrm{Q}=$ Cerdip. For outline information see Package Information section.
${ }^{2}$ Refer to AD603 Military data sheet. Also available as $5962-9457203 \mathrm{MPA}$.

## THEORY OF OPERATION

The AD603 comprises a fixed-gain amplifier, preceded by a broadband passive attenuator of 0 to 42.14 dB , having a gaincontrol scaling factor of 40 dB per volt. The fixed gain is lasertrimmed in two ranges, to either $31.07 \mathrm{~dB}(\times 35.8)$ or 50 dB ( $\times 358$ ), or may be set to any range in between using one external resistor between Pins 5 and 7. Somewhat higher gain can be obtained by connecting the resistor from Pin 5 to common, but the increase in output offset voltage limits the maximum gain to about 60 dB . For any given range, the bandwidth is independent of the voltage-controlled gain. This system provides an under- an over-range of 1.07 dB in all cases; for example, the overall gain is -11.07 dB to 31.07 dB in the maximumbandwidth mode (Pin 5 and Pin 7 strapped).
This $X$ - $A M P$ structure has many advantages over former methods of gain-control based on nonlinear elements. Most importantly, the fixed-gain amplifier can use negative feedback to increase its accuracy. Since large inputs are first attenuated, the amplifier input is always small. For example, to deliver a $\pm 1 \mathrm{~V}$ output in the $-1 \mathrm{~dB} /+41 \mathrm{~dB}$ mode (that is, using a fixed amplifier gain of 41.07 dB ) its input is only 8.84 mV ; thus the distortion can be very low. Equally important, the small-signal gain and phase response, and thus the pulse response, are essentially independent of gain.
Figure 1 is a simplified schematic. The input attenuator is a seven-section R-2R ladder network, using untrimmed resistors of nominally $R=62.5 \Omega$, which results in a characteristic resistance of $125 \Omega \pm 20 \%$. A shunt resistor is included at the input and laser trimmed to establish a more exact input resistance of $100 \Omega \pm 3 \%$, which ensures accurate operation (gain and HP corner frequency) when used in conjunction with external resistors or capacitors.
The nominal maximum signal at input VINP is 1 V rms ( $\pm 1.4 \mathrm{~V}$ peak) when using the recommended $\pm 5 \mathrm{~V}$ supplies, although operation to $\pm 2 \mathrm{~V}$ peak is permissible with some increase in HF distortion and feedthrough. Pin 4 (SIGNAL COMMON) must be connected directly to the input ground; significant impedance in this connection will reduce the gain accuracy.
The signal applied at the input of the ladder network is attenuated by 6.02 dB by each section; thus, the attenuation to each of the taps is progressively $0 \mathrm{~dB}, 6.02 \mathrm{~dB}, 12.04 \mathrm{~dB}, 18.06 \mathrm{~dB}$, $24.08 \mathrm{~dB}, 30.1 \mathrm{~dB}, 36.12 \mathrm{~dB}$ and 42.14 dB . A unique circuit technique is employed to interpolate between these tap-points, indicated by the "slider" in Figure 1, thus providing continuous attenuation from 0 dB to 42.14 dB . It will help, in understanding the AD603, to think in terms of a mechanical means for moving this slider from left to right; in fact, its "position" is controlled by the voltage between Pins 1 and 2. The details of the gain-control interface are discussed later.
The gain is at all times very exactly determined, and a linear-indB relationship is automatically guaranteed by the exponential nature of the attenuation in the ladder network (the X-AMP principle). In practice, the gain deviates slightly from the ideal law, by about $\pm 0.2 \mathrm{~dB}$ peak (see, for example, Figure 16).


Figure 1. Simplified Block Diagram of the AD603

## Noise Performance

An important advantage of the X-AMP is its superior noise performance. The nominal resistance seen at inner tap points is $41.7 \Omega$ (one third of $125 \Omega$ ), which exhibits a Johnson noisespectral density (NSD) of $0.83 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ (that is, $\sqrt{4 \mathrm{kTR}}$ ) at $27^{\circ} \mathrm{C}$, which is a large fraction of the total input noise. The first stage of the amplifier contributes a further $1 \mathrm{nV} / \sqrt{\mathrm{Hz}}$, for a total input noise of $1.3 \mathrm{nV} / \sqrt{\mathrm{Hz}}$. It will be apparent that it is essential to use a low resistance in the ladder network to achieve the very low specified noise level. The signal's source impedance forms a voltage divider with the AD603's $100 \Omega$ input resistance. In some applications, the resulting attenuation may be unacceptable, requiring the use of an external buffer or preamplifier to match a high impedance source to the low impedance AD603.
The noise at maximum gain (that is, at the 0 dB tap) depends on whether the input is short-circuited or open-circuited: when shorted, the minimum NSD of slightly over $1 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ is achieved; when open, the resistance of $100 \Omega$ looking into the first tap generates $1.29 \mathrm{nV} / \sqrt{\mathrm{Hz}}$, so the noise increases to a total of $1.63 \mathrm{nV} / \sqrt{\mathrm{Hz}}$. (This last calculation would be important if the AD603 were preceded by, for example, a $900 \Omega$ resistor to allow operation from inputs up to 10 V rms.) As the selected tap moves away from the input, the dependence of the noise on source impedance quickly diminishes.
Apart from the small variations just discussed, the signal-tonoise ( $\mathrm{S} / \mathrm{N}$ ) ratio at the output is essentially independent of the attenuator setting. For example, on the $-11 \mathrm{~dB} /+31 \mathrm{~dB}$ range the fixed gain of X 35.8 raises the output NSD to $46.5 \mathrm{nV} / \sqrt{\mathrm{Hz}}$. Thus, for the maximum undistorted output of 1 V rms and a 1 MHz bandwidth, the output $\mathrm{S} / \mathrm{N}$ ratio would be 86.6 dB , that is, $20 \log (1 \mathrm{~V} / 46.5 \mu \mathrm{~V})$.

## The Gain-Control Interface

The attenuation is controlled through a differential, highimpedance ( $50 \mathrm{M} \Omega$ ) input, with a scaling factor which is lasertrimmed to 40 dB per volt, that is, $25 \mathrm{mV} / \mathrm{dB}$. An internal bandgap reference ensures stability of the scaling with respect to supply and temperature variations.
When the differential input voltage $\mathrm{V}_{\mathrm{G}}=0 \mathrm{~V}$, the attenuator "slider" is centered, providing an attenuation of 21.07 dB . For the maximum bandwidth range, this results in an overall gain of $10 \mathrm{~dB}(=-21.07 \mathrm{~dB}+31.07 \mathrm{~dB})$. When the control input is -500 mV , the gain is lowered by $20 \mathrm{~dB}(=0.500 \mathrm{~V} \times 40 \mathrm{~dB} / \mathrm{V})$,
to -10 dB ; when set to +500 mV , the gain is increased by 20 dB , to 30 dB . When this interface is overdriven in either direction, the gain approaches either $-11.07 \mathrm{~dB}(=-42.14 \mathrm{~dB}+$ 31.07 dB ) or $31.07 \mathrm{~dB}(=0+31.07 \mathrm{~dB})$, respectively. The only constraint on the gain-control voltage is that it be kept within the common-mode range $(-1.2 \mathrm{~V}$ to +2.0 V assuming $+5 \mathrm{~V}$ supplies) of the gain control interface.
The basic gain of the AD603 can thus be calculated using the following simple expression:

$$
\begin{equation*}
\operatorname{Gain}(d B)=40 V_{G}+10 \tag{1}
\end{equation*}
$$

where $\mathrm{V}_{\mathrm{G}}$ is in volts. When Pins 5 and 7 are strapped (see next section) the gain becomes

$$
\text { Gain }(d B)=40 V_{G}+20 \text { for } 0 \text { to }+40 d B
$$

and

$$
\begin{equation*}
\text { Gain }(d B)=40 V_{G}+30 \text { for }+10 \text { to }+50 d B \tag{2}
\end{equation*}
$$

The high impedance gain-control input ensures minimal loading when driving many amplifiers in multiple channel or cascaded applications. The differential capability provides flexibility in choosing the appropriate signal levels and polarities for various control schemes.
For example, if the gain is to be controlled by a DAC providing a positive only ground-referenced output, the "Gain Control LO" (GNEG) pin should be biased to a fixed offset of +500 mV , to set the gain to -10 dB when "Gain Control HI" (GPOS) is at zero, and to 30 dB when at +1.00 V .
It is a simple matter to include a voltage divider to achieve other scaling factors. When using an 8 -bit DAC having a FS output of $+2.55 \mathrm{~V}(10 \mathrm{mV} / \mathrm{bit})$, a divider ratio of 2 (generating $5 \mathrm{mV} / \mathrm{bit}$ ) would result in a gain-setting resolution of $0.2 \mathrm{~dB} / \mathrm{bit}$. The use of such offsets is valuable when two AD603s are cascaded, when various options exist for optimizing the $\mathrm{S} / \mathrm{N}$ profile, as will be shown later.

## Programming the Fixed-Gain Amplifier Using Pin Strapping

 Access to the feedback network is provided at Pin 5 (FDBK). The user may program the gain of the AD603's output amplifier using this pin, as shown in Figure 2. There are three modes: in the default mode, FDBK is unconnected, providing the range $+9 \mathrm{~dB} /+51 \mathrm{~dB}$; when $\mathrm{V}_{\text {OUT }}$ and FDBK are shorted, the gain is lowered to $-11 \mathrm{~dB} /+31 \mathrm{~dB}$; when an external resistor is placed between $\mathrm{V}_{\text {OUt }}$ and FDBK any intermediate gain can be achieved, for example, $-1 \mathrm{~dB} /+41 \mathrm{~dB}$. Figure 3 shows the nominal maximum gain versus external resistor for this mode.
a. -10 dB to $+30 \mathrm{~dB} ; 90 \mathrm{MHz}$ Bandwidth

b. 0 dB to $40 \mathrm{~dB} ; 45 \mathrm{MHz}$ Bandwidth

c. +10 dB to $50 \mathrm{~dB} ; 9 \mathrm{MHz}$ Bandwidth

Figure 2. Pin Strapping to Set Gain


Figure 3. Gain vs. $R_{E X T}$, Showing Worst-Case Limits Assuming Internal Resistors Have a Maximum Tolerance of $20 \%$

Optionally, when a resistor is placed from FDBK to COMM, higher gains can be achieved. This fourth mode is of limited value because of the low bandwidth and the elevated output offsets; it is thus not included in Figure 2.

The gain of this amplifier in the first two modes is set by the ratio of on-chip laser-trimmed resistors. While the ratio of these resistors is very accurate, the absolute value of these resistors can vary by as much as $\pm 20 \%$. Thus, when an external resistor is connected in parallel with the nominal $6.44 \mathrm{k} \Omega \pm 20 \%$ internal resistor, the overall gain accuracy is somewhat poorer. The worst-case error occurs at about $2 \mathrm{k} \Omega$ (see Figure 4).


Figure 4. Worst-Case Gain Error, Assuming Internal Resistors Have a Maximum Tolerance of -20\% (Top Curve) or +20\% (Bottom Curve)

While the gain-bandwidth product of the fixed-gain amplifier is about 4 GHz , the actual bandwidth is not exactly related to the maximum gain. This is because there is a slight enhancing of the ac response magnitude on the maximum bandwidth range, due to higher order poles in the open-loop gain function; this mild peaking is not present on the higher gain ranges. Figure 2 shows how optional capacitors may be added to extend the frequency response in high gain modes.

## CASCADING TWO AD603s

Two or more AD603s can be connected in series to achieve higher gain. Invariably, ac coupling must be used to prevent the dc offset voltage at the output of each amplifier from overloading the following amplifier at maximum gain. The required high pass coupling network will usually be just a capacitor, chosen to set the desired corner frequency in conjunction with the welldefined $100 \Omega$ input resistance of the following amplifier.
For two AD603s, the total gain-control range becomes 84 dB (two times 42.14 dB ); the overall -3 dB bandwidth of cascaded stages will be somewhat reduced. Depending on the pinstrapping, the gain and bandwidth for two cascaded amplifiers can range from -22 dB to +62 dB (with a bandwidth of about 70 MHz ) to +22 dB to +102 dB (with a bandwidth of about 6 MHz ).
There are several ways of connecting the gain-control inputs in cascaded operation. The choice depends on whether it is important to achieve the highest possible Instantaneous Signal-toNoise Ratio (ISNR), or, alternatively, to minimize the ripple in the gain error. The following examples feature the AD603 programmed for maximum bandwidth; the explanations apply to other gain/bandwidth combinations with appropriate changes to the arrangements for setting the maximum gain.

## Sequential Mode (Optimal S/N Ratio)

In the sequential mode of operation, the ISNR is maintained at its highest level for as much of the gain control range possible. Figure 5, shows the SNR over a gain range of -22 dB to +62 dB , assuming an output of 1 V rms and a 1 MHz bandwidth; Figure 6 shows the general connections to accomplish this. Here, both the positive gain-control inputs (GPOS) are driven in parallel by a positive-only, ground-referenced source with a range of 0 V to +2 V , while the negative gain-control inputs (GNEG) are biased by stable voltages to provide the needed gain-offsets. These voltages may be provided by resistive dividers operating from a common voltage reference.


Figure 5. SNR vs. Control Voltage-Sequential Control (1 MHz) Bandwidth)

The gains are offset (Figure 7) such that A2's gain is increased only after Al's gain has reached its maximum value. Note that for a differential input of -600 mV or less, the gain of a single amplifier (A1 or A2) will be at its minimum value of -11.07 dB ; for a differential input of +600 mV or more, the gain will be at its maximum value of 31.07 dB . Control inputs beyond these limits will not affect the gain and can be tolerated without damage or foldover in the response. This is an important aspect of the AD603's gain-control response. (See the Specifications section of this data sheet for more details on the allowable voltage range). The gain is now

$$
\begin{equation*}
\operatorname{Gain}(d B)=40 V_{G}+G_{O} \tag{3}
\end{equation*}
$$

where $V_{G}$ is the applied control voltage and $G_{O}$ is determined by the gain range chosen. In the explanatory notes that follow, we assume the maximum-bandwidth connections are used, for which $G_{O}$ is -20 dB .


Figure 7. Explanation of Offset Calibration for Sequential Control


Figure 6. AD603 Gain Control Input Calculations for Sequential Control Operation

With reference to Figure 6, note that $\mathrm{V}_{\mathrm{G} 1}$ refers to the differential gain-control input to A 1 and $\mathrm{V}_{\mathrm{G} 2}$ refers to the differential gain-control input to A 2 . When $\mathrm{V}_{\mathrm{G}}$ is zero, $\mathrm{V}_{\mathrm{G} 1}=-473 \mathrm{mV}$ and thus the gain of A 1 is -8.93 dB (recall that the gain of each individual amplifier in the maximum-bandwidth mode is -10 dB for $\mathrm{V}_{\mathrm{G}}=-500 \mathrm{mV}$ and 10 dB for $\mathrm{V}_{\mathrm{G}}=0 \mathrm{~V}$ ); meanwhile, VG2 $=-1.908 \mathrm{~V}$ so the gain of A 2 is "pinned" at -11.07 dB . The overall gain is thus -20 dB . This situation is shown in Figure 6a.
When $\mathrm{V}_{\mathrm{G}}=+1.00 \mathrm{~V}, \mathrm{~V}_{\mathrm{G} 1}=1.00 \mathrm{~V}-0.473 \mathrm{~V}=+0.526 \mathrm{~V}$, which sets the gain of A 1 to at nearly its maximum value of 31.07 dB , while $\mathrm{V}_{\mathrm{G} 2}=1.00 \mathrm{~V}-1.526 \mathrm{~V}=-0.526 \mathrm{~V}$, which sets A2's gain at nearly its minimum value -11.07 dB . Close analysis shows that the degree to which neither AD603 is completely pushed to its maximum or minimum gain exactly cancels in the overall gain, which is now +20 dB . This is depicted in Figure 6b.
When $\mathrm{V}_{\mathrm{G}}=+2.0 \mathrm{~V}$, the gain of Al is pinned at 31.07 dB and that of A2 is near its maximum value of 28.93 dB , resulting in an overall gain of 60 dB (see Figure 6c). This mode of operation is further clarified by Figure 8, which is a plot of the separate gains of A1 and A2 and the overall gain versus the control voltage. Figure 9 is a plot of the gain error of the cascaded amplifiers versus the control voltage. Figure 10 is a plot of the gain error of the cascaded stages versus the control voltages.


Figure 8. Plot of Separate and Overall Gains in Sequential Control


Figure 9. SNR for Cascaded Stages-Sequential Control


Figure 10. Gain Error for Cascaded Stages-Sequential Control

## Parallel Mode (Simplest Gain-Control Interface)

In this mode, the gain-control of voltage is applied to both inputs in parallel-the GPOS pins of both A1 and A2 are connected to the control voltage and the GNEW inputs are grounded. The gain scaling is then doubled to $80 \mathrm{~dB} / \mathrm{V}$, requiring only a 1.00 V change for an 80 dB change of gain:

$$
\begin{equation*}
\operatorname{Gain}(d B)=80 V_{G}+G_{O} \tag{4}
\end{equation*}
$$

where, as before $G_{O}$ depends on the range selected; for example, in the maximum-bandwidth mode, $\mathrm{G}_{\mathrm{O}}$ is +20 dB . Alternatively, the GNEG pins may be connected to an offset voltage of +0.500 V , in which case, $\mathrm{G}_{\mathrm{O}}$ is -20 dB .
The amplitude of the gain ripple in this case is also doubled, as shown in Figure 11, while the instantaneous signal-to-noise ratio at the output of A2 now decreases linearly as the gain increased (Figure 12).


Figure 11. Gain Error for Cascaded Stages - Parallel Control

## Low Gain Ripple Mode (Minimum Gain Error)

As can be seen from Figures 9 and 10, the error in the gain is periodic, that is, it shows a small ripple. (Note that there is also a variation in the output offset voltage, which is due to the gain


Figure 12. ISNR for Cascaded Stages-Parallel Control
interpolation, but this is not exact in amplitude.) By offsetting the gains of A1 and A2 by half the period of the ripple, that is, by 3 dB , the residual gain errors of the two amplifiers can be made to cancel. Figure 13 shows that much lower gain ripple when configured in this manner. Figure 14 plots the ISNR as a function of gain; it is very similar to that in the "Parallel Mode."


Figure 13. Gain Error for Cascaded Stages-Low Ripple Mode


Figure 14. ISNR vs. Control Voltage-Low Ripple Mode

## THEORY OF THE AD603

## A Low Noise AGC Amplifier

Figure 15 shows the ease with which the AD603 can be connected as an AGC amplifier. The circuit illustrates many of the points previously discussed: It uses few parts, has linear-in-dB gain, operates from a single supply, uses two cascaded amplifiers in sequential gain mode for maximum $\mathrm{S} / \mathrm{N}$ ratio, and an external resistor programs each amplifier's gain. It also uses a simple temperature-compensated detector.
The circuit operates from a single 10 V supply. Resistors R1, R 2 and R3, R4 bias the common pins of A1 and A2 at 5 V . This pin is a low impedance point and must have a low impedance path to ground, here provided by the $100 \mu \mathrm{~F}$ tantalum capacitors and the $0.1 \mu \mathrm{~F}$ ceramic capacitors.
The cascaded amplifiers operate in sequential gain. Here, the offset voltage between the pins 2 (GNEG) of A1 and A2 is 1.05 V ( $42.14 \mathrm{~dB} \times 25 \mathrm{mV} / \mathrm{dB}$ ), provided by a voltage divider consisting of resistors R5, R6, and R7. Using standard values, the offset is not exact but it is not critical for this application.
The gain of both A1 and A2 is programmed by resistors R13 and R14, respectively, to be about 42 dB ; thus the maximum gain of the circuit is twice that, or 84 dB . The gain-control range can be shifted up by as much as 20 dB by appropriate choices of R13 and R14.

The circuit operates as follows. A1 and A2 are cascaded. Capacitor Cl and the $100 \Omega$ of resistance at the input of Al form a time-constant of $10 \mu \mathrm{~s}$. C2 blocks the small dc offset voltage at the output of Al (which might otherwise saturate A 2 at its maximum gain) and introduces a high-pass corner at about 16 kHz , eliminating low frequency noise.
A half-wave detector is used, based on Q1 and R8. The current into capacitor $\mathrm{C}_{\mathrm{AV}}$ is just the difference between the collector current of Q2 (biased to be $300 \mu \mathrm{~A}$ at $300 \mathrm{~K}, 27^{\circ} \mathrm{C}$ ) and the collector current of Q 1 , which increases with the amplitude of the output signal. The automatic gain control voltage, $\mathrm{V}_{\mathrm{AGC}}$, is the time-integral of this error current. In order for $\mathrm{V}_{\mathrm{AGC}}$ (and thus the gain) to remain insensitive to short-term amplitude fluctuations in the output signal, the rectified current in Q1 must, on average, exactly balance the current in Q2. If the output of A2 is too small to do this, $\mathrm{V}_{\mathrm{AGC}}$ will increase, causing the gain to increase, until Q1 conducts sufficiently.

Consider the case where R 8 is zero and the output voltage $\mathrm{V}_{\text {OUT }}$ is a square wave at, say, 455 kHz , that is, well above the corner frequency of the control loop.

During the time $\mathrm{V}_{\text {OUt }}$ is negative with respect to the base voltage of Q1, Q1 conducts; when $\mathrm{V}_{\text {OUT }}$ is positive, it is cut off. Since the average collector current of Q1 is forced to be $300 \mu \mathrm{~A}$, and the square wave has a duty-cycle of $1: 1, \mathrm{Ql}$ 's collector current when conducting must be $600 \mu \mathrm{~A}$. With R8 omitted, the peak amplitude of $\mathrm{V}_{\mathrm{OUT}}$ is forced to be just the $\mathrm{V}_{\mathrm{BE}}$ of Q 1 at $600 \mu \mathrm{~A}$, typically about 700 mV , or $2 \mathrm{~V}_{\mathrm{BE}}$ peak-to-peak. This voltage, hence the amplitude at which the output stabilizes, has a strong negative temperature coefficient (TC), typically -1.7 $\mathrm{mV} /{ }^{\circ} \mathrm{C}$. Although this may not be troublesome in some applications, the correct value of R8 will render the output stable with temperature.
To understand this, first note that the current in Q2 is made to be proportional to absolute temperature (PTAT). For the moment, continue to assume that the signal is a square wave.

When Q1 is conducting, $\mathrm{V}_{\text {OUT }}$ is now the sum of $\mathrm{V}_{\mathrm{BE}}$ and a voltage which is PTAT and which can be chosen to have an equal but opposite TC to that of the $\mathrm{V}_{\mathrm{BE}}$. This is actually nothing more than an application of the "bandgap voltage reference" principle. When R8 is chosen such that the sum of the voltage across it and the $\mathrm{V}_{\mathrm{BE}}$ of Q1 is close to the bandgap voltage of about $1.2 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}$ will be stable over a wide range of temperatures, provided, of course, that Q1 and Q2 share the same thermal environment.
Since the average emitter current is $600 \mu \mathrm{~A}$ during each halfcycle of the square wave a resistor of $833 \Omega$ would add a PTAT voltage of 500 mV at 300 K , increasing by $1.66 \mathrm{mV} /{ }^{\circ} \mathrm{C}$. In practice, the optimum value will depend on the type of transistor used, and, to a lesser extent, on the waveform for which the temperature stability is to be optimized; for the inexpensive 2N3904/2N306 pair and sine wave signals, the recommended value is $806 \Omega$.

This resistor also serves to lower the peak current in Q1 when more typical signals (usually, sinusoidal) are involved, and the 1.8 kHz LP filter it forms with $\mathrm{C}_{\mathrm{AV}}$ helps to minimize distortion due to ripple in VAGC. Note that the output amplitude under sinewave conditions will be higher than for a square wave, since the average value of the current for an ideal rectifier would be 0.637 times as large, causing the output amplitude to
be 1.88 ( $=1.2 / 0.637$ ) V , or 1.33 V rms. In practice, the somewhat nonideal rectifier results in the sine wave output being regulated to about 1.4 V rms , or 3.6 V p-p.

The bandwidth of the circuit exceeds 40 MHz . At 10.7 MHz , the AGC threshold is $100 \mu \mathrm{~V}(-67 \mathrm{dBm})$ and its maximum gain is $83 \mathrm{~dB}(20 \log 1.4 \mathrm{~V} / 100 \mu \mathrm{~V})$. The circuit holds its output at 1.4 V rms for inputs as low as -67 dBm to $+15 \mathrm{dBm}(82 \mathrm{~dB})$, where the input signal exceeds the AD603's maximum input rating. For a -30 dBm input at 10.7 MHz , the second harmonic is 34 dB down from the fundamental and the third harmonic is 35 dB down.

## CAUTION

Careful component selection, circuit layout, power-supply decoupling, and shielding are needed to minimize the AD603's susceptibility to interference from radio and TV stations, etc. In bench evaluation, we recommend placing all of the components in a shielded box and using feedthrough decoupling networks for the supply voltage. Circuit layout and construction are also critical, since stray capacitances and lead inductances can form resonant circuits and are a potential source of circuit peaking, oscillation, or both.


NOTES:
1 RT PROVIDES A $50 \Omega$ INPUT IMPEDANCE
2 C3 AND C5 ARE TANTALUM
Figure 15. A Low Noise AGC Amplifier


Figure 16. Gain Error vs. Gain Control Voltage at $455 \mathrm{kHz}, 10.7 \mathrm{MHz}$, $45 \mathrm{MHz}, 70 \mathrm{MHz}$


Figure 17. Frequency and Phase Response vs. Gain (Gain $=-10 \mathrm{~dB}$, $P_{\text {IN }}=-30 \mathrm{dBm}$, Pin 5 Connected to Pin 7)


Figure 18. Frequency and Phase Response vs. Gain (Gain $=+10 \mathrm{~dB}$, $P_{\text {IN }}=-30 \mathrm{dBm}$, Pin 5 Connected to Pin 7)


Figure 19. Frequency and Phase
Response vs. Gain (Gain $=+30 \mathrm{~dB}$, $P_{\text {IN }}=-30 \mathrm{dBm}$, Pin 5 Connected to Pin 7)


Figure 21. Third Order Intermodulation Distortion Test Setup


Figure 20. Group Delay vs. Gain Control Voltage


Figure 22. Third Order Intermodulation Distortion at 455 kHz (10× Probe Used to HP3585A Spectrum Analyzer, Gain $=0 \mathrm{~dB}, P_{I N}=0 \mathrm{dBm}$, Pin 5 Connected to Pin 7)


Figure 23. Third Order Intermodulation Distortion at 10.7 MHz (10x Probe Used to HP3585A Spectrum Analyzer, Gain $=0 \mathrm{~dB}, P_{I N}=0 \mathrm{dBm}$, Pin 5 Connected to Pin 7)


Figure 26. Input Impedance vs. Frequency (Gain $=+10 \mathrm{~dB}$ )


Figure 29. Input Stage Overload
Recovery Time, Pin 5 Connected to
Pin 7 (Input Is 500 ns Period, 50\% Duty-Cycle Square Wave, Output Is Captured Using Tektronix 11402 Digitizing Oscilloscope)


Figure 24. Typical Output Voltage Swing vs. Load Resistance (Negative Output Swing Limits First)


Figure 27. Input Impedance vs. Frequency (Gain $=+30 \mathrm{~dB}$ )


Figure 30. Output Stage Overload Recovery Time, Pin 5 Connected to Pin 7 (Input is 500 ns Period, 50\% Duty-Cycle Square Wave, Output Is Captured Using Tektronix 11402 Digitizing Oscilloscope)


Figure 31. Transient Response, $G=0 \mathrm{~dB}$, Pin 5 Connected to Pin 7 (Input is 500 ns Period, 50\% DutyCycle Square Wave, Output Is Captured Using Tektronix 11402 Digitizing Oscilloscope)


Figure 32. Transient Response, $G=+20 d B$, Pin 5 Connected to Pin 7 (Input is 500 ns Period, 50\% DutyCycle Square Ware, Output Is Captured Using Tektronix 11402 Digitizing Oscilloscope)


Figure 33. PSRR vs. Frequency (Worst-Case is Negative Supply PSRR, Shown Here)

## FEATURES

Logarithmic Amplifier Performance
-75 dBm to $\mathbf{+ 5 \mathrm { dBm } \text { Dynamic Range }}$
$\leq 1.5 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ Input Noise
Usable to $>50 \mathrm{MHz}$
$37.5 \mathrm{mV} / \mathrm{dB}$ Voltage Output
On-Chip Low-Pass Output Filter
Limiter Performance
$\pm 1 \mathrm{~dB}$ Output Flatness over $\mathbf{8 0 ~ d B ~ R a n g e ~}$
$\pm 3^{\circ}$ Phase Stability at $10.7 \mathbf{M H z}$ over $\mathbf{8 0} \mathrm{dB}$ Range
Adjustable Output Amplitude
Low Power
+5 V Single Supply Operation
65 mW Typical Power Consumption
CMOS Compatible Power-Down to $325 \mu \mathrm{~W}$ typ
$<5 \mu \mathrm{~s}$ Enable/Disable Time

## APPLICATIONS

Ultrasound and Sonar Processing
Phase-Stable Limiting Amplifier to $100 \mathbf{M H z}$
Received Signal Strength Indicator (RSSI)
Wide Range Signal and Power Measurement

## PRODUCT DESCRIPTION

The AD606 is a complete, monolithic logarithmic amplifier using a 9 -stage "successive-detection" technique. It provides both logarithmic and limited outputs. The logarithmic output is from a three-pole post-demodulation low-pass filter and provides
a loadable output voltage of +0.1 V dc to +4 V dc. The logarithmic scaling is such that the output is +0.5 V for a sinusoidal input of -75 dBm and +3.5 V at an input of +5 dBm ; over this range the logarithmic linearity is typically within $\pm 0.4 \mathrm{~dB}$. All scaling parameters are proportional to the supply voltage.
The AD606 can operate above and below these limits, with reduced linearity, to provide as much as 90 dB of conversion range. A second low-pass filter automatically nulls the input offset of the first stage down to the submicrovolt level. Adding external capacitors to both filters allows operation at input frequencies as low as a few hertz.
The AD606's limiter output provides a hard-limited signal output as a differential current of $\pm 1.2 \mathrm{~mA}$ from open-collector outputs. In a typical application, both of these outputs are loaded by $200 \Omega$ resistors to provide a voltage gain of more than 90 dB from the input. Transition times are 1.5 ns , and the phase is stable to within $\pm 3^{\circ}$ at 10.7 MHz for signals from -75 dBm to +5 dBm .

The logarithmic amplifier operates from a single +5 V supply and typically consumes 65 mW . It is enabled by a CMOS logiclevel voltage input, with a response time of $<5 \mu \mathrm{~s}$. When disabled, the standby power is reduced to $<1 \mathrm{~mW}$ within $5 \mu \mathrm{~s}$.

The AD606J is specified for the commercial temperature range of $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ and is available in 16 -pin plastic DIPs or SOICs. Consult the factory for other packages and temperature ranges.

FUNCTIONAL BLOCK DIAGRAM



Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.
Specifications subject to change without notice.

ABSOLUTE MAXIMUM RATINGS*
Supply Voltage V $_{\text {POs }}$. . . . . . . . . . . . . . . . . . . . . . . . +9 V
Internal Power Dissipation ${ }^{1}$. . . . . . . . . . . . . . . . . . 600 mW
Operating Temperature Range . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature, Soldering $60 \mathrm{sec} . . .2 . . . . . .+300^{\circ} \mathrm{C}$
NOTES
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended rating conditions for extended periods may affect device reliability.
${ }^{1}$ Thermal Characteristics:
16-Pin Plastic DIP Package: $\theta_{\mathrm{JA}}=85^{\circ} \mathrm{C} / \mathrm{W}$
16-Pin SOIC Package: $\theta_{\mathrm{JA}}=100^{\circ} \mathrm{C} / \mathrm{W}$

ORDERING GUIDE

| Model | Temperature <br> Range | Package ${ }^{\star}$ |
| :--- | :--- | :--- |
| AD606JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 16-Pin Plastic DIP (N-16) |
| AD606JR | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 16-Pin Narrow-Body SOIC (R-16A) |

*For outline information see Package Information section.

PIN FUNCTIONS


## INPUT LEVEL CONVENTIONS

RF logarithmic amplifiers usually have their input specified in " dBm ," meaning "decibels with respect to 1 mW ." Unfortunately, this is not precise for several reasons.

1. Log amps respond not to power but to voltage. In this respect, it would be less ambiguous to use "dBV" (decibels referred to 1 V ) as the input metric. Also, power is dependent on the rms (root-mean-square) value of the signal, while log amps are not inherently rms responding.
2. The response of a demodulating $\log$ amp depends on the waveform. Convention assumes that the input is sinusoidal. However, the AD606 is capable of accurately handling any input waveform, including ac voltages, pulses and square waves, Gaussian noise, and so on. See the AD640 data sheet, which covers the effect of waveform on logarithmic intercept, for more information.
3. The impedance in which the specified power is measured is not always stated. In the $\log$ amp context it is invariably assumed to be $50 \Omega$. Thus, 0 dBm means " 1 mW rms in $50 \Omega$," and corresponds to an rms voltage of $\sqrt{(1 \mathrm{~mW} \times 50 \Omega)}$, or 224 mV .
Popular convention requires the use of dBm to simplify the comparison of $\log \mathrm{amp}$ specifications. Unless otherwise stated, sinusoidal inputs expressed as dBm in $50 \Omega$ are used to specify the performance of the AD606 throughout this data sheet. We will also show the corresponding rms voltages where it helps to clarify the specification. Noise levels will likewise be given in dBm ; the response to Gaussian noise is 0.5 dB higher than for a sinusoidal input of the same rms value.
Note that dynamic range, being a simple ratio, is always specified simply as " dB ", and the slope of the logarithmic transfer function is correctly specified as " $\mathrm{mV} / \mathrm{dB}$," NOT as " $\mathrm{mV} / \mathrm{dBm}$."

## LOGARITHMIC SLOPE AND INTERCEPT

A generalized logarithmic amplifier having an input voltage $\mathrm{V}_{\text {IN }}$ and output voltage $\mathrm{V}_{\text {LOG }}$ must satisfy a transfer function of the form

$$
V_{L O G}=V_{Y} \log _{10}\left(V_{I N} / V_{X}\right)
$$

where, in the case of the AD606, the voltage $\mathrm{V}_{\text {IN }}$ is the difference between the voltages on pins INHI and INLO, and the voltage $V_{\text {LOG }}$ is that measured at the output pin VLOG. $\mathrm{V}_{\mathbf{Y}}$ and $\mathbf{V}_{\mathbf{X}}$ are fixed voltages that determine the slope and intercept of the logarithmic amplifier, respectively. These parameters are inherent in the design of a particular logarithmic amplifier, although may be adjustable, as in the AD606. When $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{x}}$, the logarithmic argument is one, hence the logarithm is zero. $\mathrm{V}_{\mathbf{X}}$ is, therefore, called the logarithmic intercept voltage because the output voltage $\mathrm{V}_{\text {LOG }}$ crosses zero for this input. The slope voltage $\mathrm{V}_{\mathrm{Y}}$ is can also be interpreted as the "volts per decade" when using base-10 logarithms as shown here.
Note carefully that $\mathrm{V}_{\text {LOG }}$ and VLOG in the above paragraph (and elsewhere in this data sheet) are different. The first is a voltage; the second is a pin designation.
This equation suggests that the input $\mathrm{V}_{\mathrm{IN}}$ is a dc quantity, and, if $\mathrm{V}_{\mathbf{x}}$ is positive, that $\mathrm{V}_{\mathrm{IN}}$ must likewise be positive, since the logarithm of a negative number has no simple meaning. In fact, in the AD606, the response is independent of the sign of $V_{I N}$. because of the particular way in which the circuit is built. This is part of the demodulating nature of the amplifier, which
results in an alternating input voltage being transformed into a quasi-dc (rectified and filtered) output voltage.
The single supply nature of the AD606 results in common-mode level of the inputs INHI and INLO being at about +2.5 V (using the recommended +5 V supply). In normal ac operation, this bias level is developed internally and the input signal is coupled in through dc-blocking capacitors. Any residual dc offset voltage in the first stage limits the logarithmic accuracy for small inputs. In ac operation, this offset is automatically and continuously nulled via a feedback path from the last stage, provided that the pins INHI and INLO are not shorted together, as would be the case if transformer coupling were used for the signal.
While any logarithmic amplifier must eventually conform to the basic equation shown above, which, with appropriate elaboration, can also fully account for the effect of the signal waveform on the effective intercept, ${ }^{1}$ it is more convenient in RF applications to use a simpler expression. This simplification results from first, assuming that the input is always sinusoidal, and second, using a decibel representation for the input level. The standard representation of RF levels is (incorrectly, in a log amp context) in terms of power, specifically, decibels above 1 milliwatt ( dBm ) with a presumed impedance level of $50 \Omega$. That being the case, we can rewrite the transfer function as

$$
V_{L O G}=V_{Y}\left(P_{I N}-P_{X}\right)
$$

where it must be understood that $\mathrm{P}_{\mathrm{IN}}$ means the sinusoidal input power level in a $50 \Omega$ system, expressed in dBm , and $\mathrm{P}_{\mathrm{X}}$ is the intercept, also expressed in dBm . In this case, $\mathrm{P}_{\mathrm{IN}}$ and $\mathrm{P}_{\mathbf{x}}$ are simple, dimensionless numbers. ( $\mathrm{P}_{\mathrm{x}}$ is sometimes called the "logarithmic offset," for reasons which are obvious from the above equation.) $\mathrm{V}_{\mathrm{Y}}$ is still defined as the logarithmic slope, usually specified as so many millivolts per decibel, or $\mathrm{mV} / \mathrm{dB}$.
In the case of the AD606, the slope voltage, $\mathrm{V}_{\mathrm{Y}}$, is nominally 750 mV when operating at $\mathrm{V}_{\mathrm{POS}}=5 \mathrm{~V}$. This can also be expressed as $37.5 \mathrm{mV} / \mathrm{dB}$ or $750 \mathrm{mV} /$ decade; thus, the 80 dB range equates to 3 V . Figure 1 shows the transfer function of the AD606. The slope is closely proportional to $\mathrm{V}_{\mathrm{POS}}$, and can more generally be stated as $\mathrm{Y}_{\mathrm{Y}}=0.15 \times \mathrm{V}_{\mathrm{POs}}$. Thus, in those applications where the scaling must be independent of supply voltage, this must be stabilized to the required accuracy. In applications where the output is applied to an A/D converter,


Figure 1. Nominal Transfer Function

[^266]the reference for that converter should be a fractional part of $\mathrm{V}_{\mathrm{POS}}$, if possible. The slope is essentially independent of temperature.
The intercept $\mathbf{P}_{\mathbf{x}}$ is essentially independent of either the supply voltage or temperature. However, the AD606 is not factorycalibrated, and both the slope and intercept may need to be externally adjusted. Following calibration, the conformance to an ideal logarithmic law will be found to be very close, particularly at moderate frequencies (see Figure 14), and still acceptable at the upper end of the frequency range (Figure 15).

## CIRCUIT DESCRIPTION

Figure 2 is a block diagram of the AD606, which is a complete logarithmic amplifier system in monolithic form. It uses a total of nine limiting amplifiers in a "successive detection" scheme to closely approximate a logarithmic response over a total dynamic range of 90 dB (Figure 2). The signal input is differential, at nodes INHI and INLO, and will usually be sinusoidal and ac coupled. The source may be either differential or single-sided; the input impedance is about $2.5 \mathrm{k} \Omega$ in parallel with 2 pF . Seven of the amplifier/detector stages handle inputs from -80 $\mathrm{dBm}(32 \mu \mathrm{~V} \mathrm{rms})$ up to about $-14 \mathrm{dBm}(45 \mathrm{mV} \mathrm{rms})$. The noise floor is about -83 dBm ( $18 \mu \mathrm{~V} \mathrm{rms}$ ). Another two stages receive the input attenuated by 22.3 dB , and respond to inputs up to +10 dBm ( 707 mV rms ). The gain of each of these stages is 11.15 dB and is accurately stabilized over temperature by a precise biasing system.
The detectors provide full-wave rectification of the alternating signal present at each limiter output. Their outputs are in the form of currents, proportional to the supply voltage. Each cell incorporates a low-pass filter pole, as the first step in recovering the average value of the demodulated signal, which contains appreciable energy at even harmonics of the input frequency. A further real pole can be introduced by adding a capacitor between the summing node ISUM and VPOS. The summed detector output currents are applied to a $6: 1$ reduction current mirror. Its output at ILOG is scaled $2 \mu \mathrm{~A} / \mathrm{dB}$, and is converted to voltage by an internal load resistor of $9.375 \mathrm{k} \Omega$ between ILOG and OPCM (output common, which is usually grounded).

The nominal slope at this point is $18.75 \mathrm{mV} / \mathrm{dB}(375 \mathrm{mV} /$ decade).
In applications where $\mathrm{V}_{\text {LOG }}$ is taken to an $\mathrm{A} / \mathrm{D}$ converter which allows the use of an external reference, this reference input should also be connected to the same +5 V supply. The powersupply voltage may be in the range +4.5 V to +5.5 V , providing a range of slopes from nominally $33.75 \mathrm{mV} / \mathrm{dB}(675 \mathrm{mV} /$ decade) to $41.25 \mathrm{mV} / \mathrm{dB}$ ( $825 \mathrm{mV} /$ decade).
A buffer amplifier, having a gain of two, provides a final output scaling at $\mathrm{V}_{\text {LOG }}$ of $37.5 \mathrm{mV} / \mathrm{dB}$ ( $750 \mathrm{mV} /$ decade). This lowimpedance output can run from close to ground to over +4 V (using the recommended +5 V supply) and is tolerant of resistive and capacitive loads. Further filtering is provided by a conjugate pole pair, formed by internal capacitors which are an integral part of the output buffer. The corner frequency of the overall filter is 2 MHz , and the $10 \%-90 \%$ rise time is 150 ns . Later, we will show how the slope and intercept can be altered using simple external adjustments. The direct buffer input BFIN is used in these cases.

The last limiter output is available as complementary currents from open collectors at pins LMHI and LMLO. These currents are each 1.2 mA typical with LADJ grounded and may be converted to voltages using external load resistors connected to VPOS; typically, a $200 \Omega$ resistor is used on just one output. The voltage gain is then over 90 dB , resulting in a hard-limited output for all input levels down to the noise floor. The phasing is such that the voltage at LMHI goes high when the input (INHI to INLO) is positive. The overall delay time from the signal inputs to the limiter outputs is 8 ns . Of particular importance is the phase stability of these outputs versus input level. At 50 MHz , the phase typically remains within $\pm 4^{\circ}$ from -70 dBm to +5 dBm . The rise time of this output (essentially a square wave) is about 1.2 ns , resulting in clean operation to more than 70 MHz .

## Offset-Control Loop

The offset-control loop nulls the input offset voltage, and sets up the bias voltages at the input pins INHI and INLO. A full understanding of this offset-control loop is useful, particularly

when using larger input coupling capacitors and an external filter capacitor to lower the minimum acceptable operating frequency. The loop's primary purpose is to extend the lower end of the dynamic range in the case where the offset voltage of the first stage should be high enough to cause later stages to prematurely enter limiting, because of the high dc gain (about 8000) of the main amplifier system. For example, an offset voltage of only $20 \mu \mathrm{~V}$ would become 160 mV at the output of the last stage in the main amplifier (before the final limiter section), driving the last stage well into limiting. In the absence of noise, this limiting would simply result in the logarithmic output ceasing to become any lower below a certain signal level at the input. The offset would also degrade the logarithmic conformance in this region. In practice, the finite noise of the first stage also plays a role in this regard, even if the dc offset were zero.
Figure 3 shows a representation of this loop, reduced to essentials. The figure closely corresponds to the internal circuitry, and correctly shows the input resistance. Thus, the forward gain of the main amplifier section is $7 \times 11.15 \mathrm{~dB}$, but the loop gain is lowered because of the attenuation in the network formed by


Figure 3. Offset Control Loop
RB1 and RB2 and the input resistance RA. The connection polarity is such as to result in negative feedback, which reduces the input offset voltage by the dc loop gain, here about 50 dB , that is, by a factor of about 316 . We use a differential representation, because later we will examine the consequences to the power-up response time in the event that the ac coupling capacitors $\mathrm{C}_{\mathrm{C} 1}$ and $\mathrm{C}_{\mathrm{C} 2}$ do not exactly match. Note that these capacitors, as well as forming a high-pass filter to the signal in the forward path, also introduce a pole in the feedback path.
Internal resistors RF1 and RF2 in conjunction with grounded capacitors CF1 and CF2 form a low-pass filter at 15 kHz . This frequency can optionally be lowered by the addition of an external capacitor $C_{z}$, and in some cases a series resistor $R_{z}$. This, in conjunction with the low-pass section formed at the input coupling, results in a two-pole high-pass response, falling of at $40 \mathrm{~dB} /$ decade below the corner frequency. The damping factor of this filter depends on the ratio $C_{Z} / C_{C}$ (when $C_{z} \gg C_{F}$ ) and also on the value of $\mathrm{R}_{\mathrm{z}}$.
The inclusion of this control loop has no effect on the high frequency response of the AD606. Nor does it have any effect on the low frequency response when the input amplitude is substantially above the input offset voltage.
The loop's effect is felt only at the lower end of the dynamic range, that is, from about -80 dBm to -70 dBm , and when the signal frequency is near the lower edge of the passband. Thus,
the small signal results which are obtained using the suggested model are not indicative of the ac response at moderate to high signal levels. Figure 4 shows the response of this model for the default case (using $\mathrm{C}_{\mathrm{C}}=100 \mathrm{pF}$ and $\mathrm{C}_{\mathrm{z}}=0$ ) and with $\mathrm{C}_{\mathrm{z}}=$ 150 pF . In general, a maximally flat ac response occurs when $\mathrm{C}_{\mathrm{z}}$ is roughly twice $\mathrm{C}_{\mathrm{C}}$ (making due allowance for the internal 30 pF capacitors). Thus, for audio applications, one can use $\mathrm{C}_{\mathrm{C}}=2.7 \mu \mathrm{~F}$ and $\mathrm{C}_{\mathrm{Z}}=4.7 \mu \mathrm{~F}$ to achieve a high-pass corner $(-3 \mathrm{~dB})$ at 25 Hz .


Figure 4. Frequency Response of Offset Control Loop for $C_{z}=0 \mathrm{pF}$ and $C_{z}=150 \mathrm{pF}\left(C_{C}=100 \mathrm{pF}\right)$
However, the maximally flat ac response is not optimal in two special cases. First, where the RF input level is rapidly pulsed, the fast edges will cause the loop filter to ring. Second, ringing can also occur when using the power-up feature, and the ac coupling capacitors do not exactly match in value. We will examine the latter case in a moment. Ringing in a linear amplifier is annoying, but in a $\log \mathrm{amp}$, with its much enhanced sensitivity to near zero signals, it can be very disruptive.
To optimize the low level accuracy, that is, achieve a highlydamped pulse response in this filter, it is recommended to include a resistor $R_{Z}$ in series with an increased value of $C_{Z}$. Some experimentation may be necessary, but for operation in the range 3 MHz to 70 MHz , values of $\mathrm{C}_{\mathrm{C}}=100 \mathrm{pF}, \mathrm{C}_{\mathrm{z}}=$ 1 nF and $\mathrm{R}_{\mathrm{z}}=2 \mathrm{k} \Omega$ are near optimal. For operation down to 100 kHz use $\mathrm{C}_{\mathrm{C}}=10 \mathrm{nF}, \mathrm{C}_{\mathrm{Z}}=0.1 \mu \mathrm{~F}$ and $\mathrm{R}_{\mathrm{Z}}=13 \mathrm{k} \Omega$. Figure 5 shows typical connections for the AD606 with these filter components added.


Figure 5. Use of $C_{Z}$ and $R_{Z}$ for Offset Control Loop Compensation

For operation above 10 MHz , it is not necessary to add the external capacitors CF1, CF2, and $\mathrm{C}_{\mathrm{z}}$, although an improvement in low frequency noise can be achieved by so doing (see

APPLICATIONS). Note that the offset control loop does not materially affect the low-frequency cutoff at high input levels, when the offset voltage is swamped by the signal.

## Power-Up Interface

The AD606 features a power-saving mode, controlled by the logic level at Pin 14 (PRUP). When powered down, the quiescent current is typically $65 \mu \mathrm{~A}$, or about $325 \mu \mathrm{~W}$. A CMOS logical HIGH applied to PRUP activates both internal references, and the system becomes fully functional within about $3.5 \mu \mathrm{~s}$. When this input is a CMOS logical LOW, the system shuts down to the quiescent level within about $5 \mu \mathrm{~s}$.
The power-up time is somewhat dependent on the signal level and can be degraded by mismatch of the input coupling capacitors. The explanation is as follows. When the AD606 makes the transition from powered-down to fully active, the dc bias voltage at the input nodes INHI and INLO (about +2.5 V ) inevitably changes slightly, as base current in the input transistors flows in the bias resistors. In fact, first-order correction for this is included in the specially designed offset buffer amplifier, but even a few millivolts of change at these inputs represents a significant equivalent " dBm " level.
Now, if the coupling capacitors do not match exactly, some fractional part of this residual voltage step becomes coupled into the amplifier. For example, if there is a $10 \%$ capacitor mismatch, and INHI and INLO jump 20 mV at power-up, there is a 2 mV pulse input to the system, which may cause the offset control loop to ring. Note that 2 mV is roughly 40 times greater than the amplitude of a sinusoidal input at -75 dBm . As long as the ringing persists, the AD606 will be "blind" to the actual input, and $V_{\text {LOG }}$ will show major disturbances.
The solution to this problem is first, to ensure that the loop filter does not ring, and second, to use well-matched capacitors at the signal input. Use the component values suggested above to minimize ringing.

## APPLICATIONS

Note that the AD606 has more than 70 MHz of input bandwidth and 90 dB of gain! Careful shielding is needed to realize its full dynamic range, since nearly all application sites will be pervaded by many kinds of interference, radio and TV stations, etc., all of which the AD606 faithfully hears. In bench evaluation, we recommend placing all of the components in a shielded box and using feedthrough decoupling networks for the supply voltage. In many applications, the AD606's low power drain allows the use of a 6 V battery inside the box.

## Basic RSSI Application

Figure 6 shows the basic RSSI (Receiver Signal Strength Indicator) application circuit, including the calibration adjustments, either or both of which may be omitted in noncritical applications. This circuit may be used "as is" in such measurement applications as the $\log /$ IF strip in a spectrum or network analyzer or, with the addition of an FM or QPSK demodulator fed by the limiter outputs, as an IF strip in such communications applications as a GSM digital mobile radio or FM receiver.
The slope adjustment works in this way: the buffer amplifier (which forms part of a Sallen-Key two-pole filter, see Figure 2) has a dc gain of plus two, and the resistance from BFIN (buffer in) to OPCM (output common) is nominally $9.375 \mathrm{k} \Omega$. This resistance is driven from the logarithmic detector sections with a current scaled $2 \mu \mathrm{~A} / \mathrm{dB}$, generating $18.75 \mathrm{mV} / \mathrm{dB}$ at BFIN, hence $37.5 \mathrm{mV} / \mathrm{dB}$ at $\mathrm{V}_{\text {LOG }}$. Now, a resistor (R4 in Figure 6) connected directly between BFIN and VLOG would form a controlled positive-feedback network with the internal $9.375 \mathrm{k} \Omega$ resistor which would raise the gain, and thus increase the slope voltage, while the same external resistor connected between BFIN and ground would form a shunt across the internal resistor and reduce the slope voltage. By connecting R4 to a potentiometer R2 across the output, the slope may be adjusted either way; the value for R4 shown in Figure 6 provides approximately $\pm 10 \%$ range, with essentially no effect on the slope at the midposition.
The intercept may be adjusted by adding a small current into BFIN via R1 and R3. The AD606 is designed to have the nominal intercept value of -88 dBm when R1 is centered using this network, which provides a range of $\pm 5 \mathrm{~dB}$.


Figure 6. Basic Application Circuit Showing Optional Slope and Intercept Adjustments

## Adjustment Procedure

The slope and intercept adjustments interact; this can be minimized by reducing the resistance of R1 and R2, chosen here to minimize power drain. Calibration can be achieved in several ways: The simplest is to apply an RF input at the desired operating frequency which is amplitude modulated at a relatively low frequency (say 1 kHz to 10 kHz ) to a known modulation index. Thus, one might choose a ratio of 2 between the maximum and minimum levels of the RF amplitude, corresponding to a 6 dB (strictly, 6.02 dB ) change in input level. The average RF level should be set to about -35 dBm (the midpoint of the AD606's range). R 2 is then adjusted so that the 6 dB input change results in the desired output voltage change, for example, 226 mV at $37.5 \mathrm{mV} / \mathrm{dB}$.
A better choice would be a $4: 1$ ratio ( 12.04 dB ), to spread the residual error out over a larger segment of the whole transfer function. If a pulsed RF generator is available, the decibel increment might be enlarged to 20 dB or more. Using just a fixedlevel RF generator, the procedure is more time consuming, but is carried out in just the same way: manually change the level by a known number of decibels and adjust R 2 until $\mathrm{V}_{\text {LOG }}$ varies by the corresponding voltage.
Having adjusted the slope, the intercept may now be simply adjusted using a known input level. A value of -35 dBm ( 397.6 mV rms , or 400 mV to within 0.05 dB ) is recommended, and if the standard scaling is used $\left(\mathrm{P}_{\mathrm{x}}=-88.33 \mathrm{dBm}, \mathrm{V}_{\mathrm{Y}}=37.5\right.$ $\mathrm{mV} / \mathrm{dB}$ ), then $\mathrm{V}_{\text {LOG }}$ should be set to +2 V at this input level.

## A Low Cost Audio Through RF Power Meter

Figure 7 shows a simple power meter that uses the AD606 and an ICL7136 3-1/2 digit DMM IC driving an LCD readout. The circuit operates from a single +5 V supply and provides direct readout in dBm , with a resolution of 0.1 dBm .

In contrast to the limited dynamic range of the diode and thermistor-styled sensors used in power meters, the AD606 can measure signals from below -80 dBm to over +10 dBm . An optional $50 \Omega$ termination is included in the figure; this could form the lower arm of an external attenuator to accommodate larger signal levels. By the simple expedient of using a 13 dB attenuator, the LCD reading now becomes dBV (decibels above 1 V rms ). This requires a series resistor of $174 \Omega$, presenting an input resistance of $224 \Omega$. Alternatively, the input resistance can be raised to $600 \Omega$ using $464 \Omega$ and $133 \Omega$. It is important to note that the AD606 inputs must be ac coupled. To extend the low frequency range, use larger coupling capacitors and an external loop filter, as outlined earlier.
The nominal 0.5 V to 3.5 V output of the AD606 (for a -75 dBm to +5 dBm input) must be scaled and level shifted to fit within the +1 V to +4.5 V common-mode range of the ICL7136 for the +5 V supply used. This is achieved by the passive resistor network of R1, R2, and R3 in conjunction with the bias networks of R4 through R7, which provide the ICL7136 with its reference voltage, and R9 through R11, which set the intercept. The ICL7136 measures the differential voltage between IN HI and IN LO, which ranges from -75 mV to +5 mV for a -75 dBm to +5 dBm input.

To calibrate the power meter, first adjust R6 for 100 mV between REF HI and REF LO. This sets the initial slope. Then adjust R10 to set IN LO 80 mV higher than IN HI. This sets the initial intercept. The slope and intercept may now be adjusted using a calibrated signal generator as outlined in the previous section.
To extend the low frequency limit of the system to audio frequencies, simply change $\mathrm{C} 1, \mathrm{C} 2$, and C 3 to $4.7 \mu \mathrm{~F}$.
The limiter output of the AD606 may be used to drive the highimpedance input of a frequency counter.


Figure 7. A Low Cost RF Power Meter


Figure 8. Circuit for Low Frequency Measurements

## Low Frequency Applications

With reasonably sized input coupling capacitors and an optional input low-pass filter, the AD606 can operate to frequencies as low as 200 Hz with good $\log$ conformance. Figure 8 shows the schematic, with the low-pass filter included in the dashed box. This circuit should be built inside a die cast box and the signal brought in through a coaxial connector. The circuit must also have a low-pass filter to reject the attenuated RF signals that would otherwise be rectified along with the desired signal and be added to the log output. The shielded and filtered circuit has a 90 dB dynamic range, as shown in Figure 9.
In this circuit, R4 and R5 form a 20 dB attenuator that extends the input range to 10 V rms. R3 isolates loads from VLOG. Capacitors C 1 and $\mathrm{C} 2(4.7 \mu \mathrm{~F}$ each), R1, R2, and the AD606's input resistance of $2.5 \mathrm{k} \Omega$ form a 100 Hz high-pass filter that is before the AD606; the corner frequency of this filter must be well below the lowest frequency of interest. In addition, the offset-correction loop introduces another pole at low signal levels that is transformed into another high-pass filter because it is in a feedback path. This indicates that there has to be a gradual transition from a 40 dB roll off at low signal levels to a 20 dB roll off at high signal levels, at which point the feedback low pass filter is effectively disabled since the incoming signal swamps the feedback signal.

This low-pass filter introduces some attenuation due to R1 and R 2 in conjunction with the $2.5 \mathrm{k} \Omega$ input resistance of the AD606. To minimize this effect, the value of R1 and R2 should be kept as small as possible- $100 \Omega$ is a good value since it balances the need to reduce the attenuation as mentioned above with the requirement for R1 and R2 to be much larger then the impedance of C 1 and C 2 at the low-pass corner frequency, in our case about 1 MHz .


Figure 9. Performance of Low Frequency Circuit at 100 Hz and 1 kHz to 10 MHz (Note Attenuation)

## AD606-Typical Characteristics



Figure 10. Normalized Limiter Amplitude Response vs. Input Level at $10.7 \mathrm{MHz}, 45 \mathrm{MHz}$ and 70 MHz


Figure 13. $V_{\text {Log }}$ Plotted vs. Input Level at 10.7 MHz as a Function of Power Supply Voltage


Figure 11. Normalized Limiter Phase Response vs. Input Level at 10.7 MHz, 45 MHz , and 70 MHz


Figure 14. Logarithmic Conformance as a Function of Input Level at 10.7 MHz at $-25^{\circ} \mathrm{C},+25^{\circ} \mathrm{C}$, and $+70^{\circ} \mathrm{C}$


Figure 17. $V_{\text {LOG }}$ Response to a 10.7 MHz CW Signal Modulated by a $25 \mu \mathrm{~s}$ Wide Pulse with a 25 kHz Repetition Rate Using 200 pF Input Coupling Capacitors. The Input Signal Goes from $+5 d B m$ to $-75 d B m$ in 20 dB Steps.


Figure 12. Supply Current vs. PRUP Voltage at $+25^{\circ} \mathrm{C}$


Figure 15. Logarithmic Conformance as a Function of Input Level at 45 MHz at $-25^{\circ} \mathrm{C},+25^{\circ} \mathrm{C}$, and $+70^{\circ} \mathrm{C}$


Figure 18. Limiter Response at Onset of 70 MHz Modulated Pulse at -55 dBm Using 200 pF Input Coupling Capacitors.


Figure 19. $V_{\text {LOG }}$ Output for a Pulsed 10.7 MHz Input; Top Trace:
-35 dBm to +5 dBm ; Middle Trace:
$-15 d B m$ to $-55 d B m$; Bottom
Trace: -35 dBm to -75 dBm


Figure 20. Example of Test Signal Used for Figure 19


Figure 21. $V_{\text {LOG }}$ Output for 10.7 MHz CW Input with PRUP Toggled ON and OFF; Top Trace:
+5 dBm Input; Middle Trace: -35
dBm Input; Bottom Trace: -75
dBm; PRUP Input from HP8112A: 0 to $4 \mathrm{~V}, 10 \mu \mathrm{~s}$ Pulse Width with 10 kHz Repetition Rate


Figure 22. Test Setup for Characterization Data

# DC Coupled Demodulating 120MHz Logarithmic Amplifier 

## FEATURES

Complete, Fully Calibrated Monolithic System Five Stages, Each Having 10dB Gain, 350MHz BW Direct Coupled Fully Differential Signal Path
Logarithmic Slope, Intercept and AC Response are Stable Over Full Military Temperature Range Dual Polarity Current Outputs Scaled 1mA/Decade
Voltage Slope Options (1V/Decade, $100 \mathrm{mV} / \mathrm{dB}$, etc.)
Low Power Operation (Typically 220 mW at $\pm 5 \mathrm{~V}$ )
Low Cost Plastic Packages Also Available

## APPLICATIONS

## Radar, Sonar, Ultrasonic and Audio Systems Precision Instrumentation from DC to $\mathbf{1 2 0 M H z}$ Power Measurement with Absolute Calibration Wide Range High Accuracy Signal Compression Alternative to Discrete and Hybrid IF Strips <br> Replaces Several Discrete Log Amp ICs

## PRODUCT DESCRIPTION

The AD640 is a complete monolithic logarithmic amplifier. A single AD640 provides up to 50 dB of dynamic range for frequencies from dc to 120 MHz . Two AD640s in cascade can provide up to 95 dB of dynamic range at reduced bandwidth. The AD640 uses a successive detection scheme to provide an output current proportional to the logarithm of the input voltage. It is laser calibrated to close tolerances and maintains high accuracy over the full military temperature range using supply voltages from $\pm 4.5 \mathrm{~V}$ to $\pm 7.5 \mathrm{~V}$.
The AD640 comprises five cascaded dc coupled amplifier/limiter stages, each having a small signal voltage gain of 10 dB and a -3 dB bandwidth of 350 MHz . Each stage has an associated fullwave detector, whose output current depends on the absolute value of its input voltage. The five outputs are summed to provide the video output (when low pass filtered) scaled at $\operatorname{lmA}$ per decade ( $50 \mu \mathrm{~A}$ per dB ). On chip resistors can be used to convert this output current to a voltage with several convenient slope options. A balanced signal output at +50 dB (referred to input) is provided to operate AD640s in cascade.
The logarithmic response is absolutely calibrated to within $\pm 1 \mathrm{~dB}$ for dc or square wave inputs from $\pm 0.75 \mathrm{mV}$ to $\pm 200 \mathrm{mV}$, with an intercept (logarithmic offset) at 1 mV dc . An integral

X10 attenuator provides an alternative input range of $\pm 7.5 \mathrm{mV}$ to $\pm 2 \mathrm{~V}$ dc. Scaling is also guaranteed for sinusoidal inputs.

The AD640B is specified for the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ and the AD640T, available processed to MIL-STD-883B, for the military range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. Both are available in 20 -pin side brazed ceramic DIPs or leadless chip carriers (LCC). The AD640J is specified for the commercial temperature range of 0 to $+70^{\circ} \mathrm{C}$, and is available in both 20 -pin plastic DIP (N) and PLCC ( P ) packages.

This device is now available to Standard Military Drawing (DESC) number 5962-9095501MRA and 5962-9095501M2A.

## PRODUCT HIGHLIGHTS

1. Absolute calibration of a wideband logarithmic amplifier is unique. The AD640 is a high accuracy measurement device, not simply a logarithmic building block.
2. Advanced design results in unprecedented stability over the full military temperature range.
3. The fully differential signal path greatly reduces the risk of instability due to inadequate power supply decoupling and shared ground connections, a serious problem with commonly used unbalanced designs.
4. Differential interfaces also ensure that the appropriate ground connection can be chosen for each signal port. They further increase versatility and simplify applications. The signal input impedance is $\sim 500 \mathrm{k} \Omega$ in shunt with $\sim 2 \mathrm{pF}$.
5. The dc coupled signal path eliminates the need for numerous interstage coupling capacitors and simplifies logarithmic conversion of subsonic signals.
6. The low input offset voltage of $50 \mu \mathrm{~V}(200 \mu \mathrm{~V} \max )$ ensures good accuracy for low level dc inputs.
7. Thermal recovery "tails," which can obscure the response when a small signal immediately follows a high level input, have been minimized by special attention to design details.
8. The noise spectral density of $2 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ results in a noise floor of $\sim 23 \mu \mathrm{~V} \mathrm{rms}(-80 \mathrm{dBm})$ at a bandwidth of 100 MHz . The dynamic range using cascaded AD640s can be extended to 95 dB by the inclusion of a simple filter between the two devices.

FUNCTIONAL BLOCK DIAGRAM


This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

DC SPECIFICATIONS ${ }_{\left(v_{s}= \pm 5,\right.} \mathrm{T}_{A}=+25^{\circ}$, unless otherwise noted)


## AC SPECIFICATIONS $N_{s}= \pm 5 V, T_{A}=+25^{\circ}$, unless otherwise noted)

| Mode |  | AD640J |  |  | AD640B |  |  | AD640T |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Parameter | Conditions | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| SIGNAL INPUT (Pins 1, 20) <br> Input Capacitance Noise Spectral Density Tangential Sensitivity | Either Pin to COM <br> 1 kHz to 10 MHz $\mathrm{BW}=100 \mathrm{MHz}$ |  | $\begin{aligned} & 2 \\ & 2 \\ & -72 \end{aligned}$ |  |  | $\begin{aligned} & 2 \\ & 2 \\ & -72 \end{aligned}$ |  |  | $\begin{aligned} & 2 \\ & 2 \\ & -72 \end{aligned}$ |  | $\begin{aligned} & \mathrm{pF} \\ & \mathrm{nV} / \sqrt{\mathrm{Hz}} \\ & \mathrm{dBm} \end{aligned}$ |
| 3dB BANDWIDTH <br> Each Stage All Five Stages | Pins 1 \& 20 to 10 \& 11 |  | $\begin{aligned} & 350 \\ & 145 \end{aligned}$ |  |  | $\begin{aligned} & 350 \\ & 145 \end{aligned}$ |  |  | $\begin{aligned} & 350 \\ & 145 \end{aligned}$ |  | $\begin{aligned} & \mathrm{MHz} \\ & \mathrm{MHz} \end{aligned}$ |
| LOGARITHMIC OUTPUTS ${ }^{6}$ <br> Slope Current, $\mathrm{I}_{\mathrm{Y}}$ $\begin{aligned} & f<=1 \mathrm{MHz} \\ & \mathrm{f}=30 \mathrm{MHz} \\ & \mathrm{f}=60 \mathrm{MHz} \\ & \mathrm{f}=90 \mathrm{MHz} \\ & \mathrm{f}=120 \mathrm{MHz} \end{aligned}$ <br> Intercept, Dual AD640s ${ }^{10,11}$ $\mathrm{f}<=1 \mathrm{MHz}$ <br> $\mathrm{f}=30 \mathrm{MHz}$ <br> $\mathrm{f}=60 \mathrm{MHz}$ <br> $\mathrm{f}=90 \mathrm{MHz}$ <br> $\mathrm{f}=120 \mathrm{MHz}$ |  | $\begin{aligned} & 0.96 \\ & 0.88 \\ & 0.82 \\ & \\ & \\ & -90.6 \end{aligned}$ | $\begin{aligned} & 1.0 \\ & 0.94 \\ & 0.90 \\ & 0.88 \\ & 0.85 \\ & -88.6 \\ & -87.6 \\ & -86.3 \\ & -83.9 \\ & -80.3 \end{aligned}$ | $\begin{aligned} & 1.04 \\ & 1.00 \\ & 0.98 \\ & \\ & \\ & -86.6 \end{aligned}$ | $\begin{aligned} & 0.98 \\ & 0.91 \\ & 0.86 \\ & \\ & \\ & -89.6 \end{aligned}$ | $\begin{aligned} & 1.0 \\ & 0.94 \\ & 0.90 \\ & 0.88 \\ & 0.85 \\ & \\ & -88.6 \\ & -87.6 \\ & -86.3 \\ & -83.9 \\ & -80.3 \end{aligned}$ | $\begin{aligned} & 1.02 \\ & 0.97 \\ & 0.94 \end{aligned}$ $-87.6$ | $\begin{aligned} & 0.98 \\ & 0.91 \\ & 0.86 \\ & \\ & \\ & -89.6 \end{aligned}$ | $\begin{aligned} & 1.0 \\ & 0.94 \\ & 0.90 \\ & 0.88 \\ & 0.85 \\ & \\ & -88.6 \\ & -87.6 \\ & -86.3 \\ & -83.9 \\ & -80.3 \end{aligned}$ | $\begin{aligned} & 1.02 \\ & 0.97 \\ & 0.94 \\ & \\ & \\ & -87.6 \end{aligned}$ | mA <br> mA <br> mA <br> mA <br> mA <br> dBm <br> dBm <br> dBm <br> dBm <br> dBm |
| AC LINEARITY <br> -40 dBm to $-2 \mathrm{dBm}^{12}$ <br> -35 dBm to $-10 \mathrm{dBm}^{12}$ <br> -75 dBm to $0 \mathrm{dBm}^{10}$ <br> -70 dBm to $-10 \mathrm{dBm}^{10}$ <br> -75 dBm to $+15 \mathrm{dBm}^{13}$ | $\begin{aligned} & \mathrm{f}=1 \mathrm{MHz} \\ & \mathrm{f}=1 \mathrm{MHz} \\ & \mathrm{f}=1 \mathrm{MHz} \\ & \mathrm{f}=1 \mathrm{MHz} \\ & \mathrm{f}=10 \mathrm{kHz} \end{aligned}$ |  | $\begin{aligned} & 0.5 \\ & 0.25 \\ & 0.75 \\ & 0.5 \\ & 0.5 \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 1.0 \\ & 3.0 \\ & 2.0 \\ & 3.0 \end{aligned}$ |  | $\begin{gathered} 0.5 \\ 0.25 \\ 0.75 \\ 0.5 \\ .0 .5 \end{gathered}$ | $\begin{aligned} & 1.0 \\ & 0.5 \\ & 1.5 \\ & 1.0 \\ & 1.5 \end{aligned}$ |  | $\begin{aligned} & 0.5 \\ & 0.25 \\ & 0.75 \\ & 0.5 \\ & 0.5 \end{aligned}$ | $\begin{aligned} & 1.0 \\ & 0.5 \\ & 1.5 \\ & 1.0 \\ & 1.5 \end{aligned}$ | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \end{aligned}$ |
| PACKAGE OPTION ${ }^{14}$ <br> 20-Pin Ceramic DIP Package (D) <br> 20-Pin Leadless Ceramic Chip Carrier (E) <br> 20-Pin Plastic DIP Package (N) <br> 20-Pin Plastic Leadless Chip Carrier (P) |  | $\begin{aligned} & \text { AD640JN } \\ & \text { AD640JP } \end{aligned}$ |  |  | $\begin{aligned} & \text { AD640BD } \\ & \text { AD640BE } \\ & \text { AD640BP } \end{aligned}$ |  |  | $\begin{aligned} & \text { AD640TD } \\ & \text { AD640TE } \end{aligned}$ |  |  |  |
| NUMBER OF TRANSISTORS |  | 155 |  |  | 155 |  |  | 155 |  |  |  |

## NOTES

${ }^{1}$ Logarithms to base 10 are used throughout. The response is independent of the sign of $\mathrm{V}_{\mathrm{IN}}$.
${ }^{2}$ Attenuation ratio trimmed to calibrate intercept to 10 mV when in use. It has a temperature coefficient of $+0.3 \% /{ }^{\circ} \mathrm{C}$.
${ }^{3}$ The zero-signal current is a function of temperature unless internal temperature compensation (ITC) pin is grounded.
${ }^{4}$ Overall gain is trimmed using a $\pm 200 \mu \mathrm{~V}$ square wave at 2 kHz , corrected for the onset of compression.
${ }^{5}$ The fully limited signal output will appear to be a square wave; its amplitude is proportional to absolute temperature.
${ }^{6}$ Currents defined as flowing into. Pin 14. See FUNDAMENTALS OF LOGARITHMIC CONVERSION for full explanation of scaling concepts. Slope is measured by linear regression over central region of transfer function.
${ }^{7}$ The logarithmic intercept in dBV (decibels relative to 1 V ) is defined as $20 \mathrm{LOG}_{10}\left(\mathrm{~V}_{\mathrm{x}} / 1 \mathrm{~V}\right.$ ).
${ }^{8}$ Operating in circuit of Figure 24 using $\pm 0.1 \%$ accurate values for $R_{L A}$ and $R_{L B}$. Includes slope and nonlinearity errors. Input offset errors also included for
$\mathrm{V}_{\text {IN }}>3 \mathrm{mV} \mathrm{dc}$, and over the full input range in ac applications.
${ }^{9}$ Essentially independent of supply voltages.
${ }^{10}$ Using the circuit of Figure 27, using cascaded AD640s and offset nulling. Input is sinusoidal, 0 dBm in $50 \Omega=223 \mathrm{mV} \mathrm{rms}$.
${ }^{11}$ For a sinusoidal signal (see EFFECT OF WAVEFORM ON INTERCEPT). Pin 8 on second AD640 must be grounded to ensure temperature stability of intercept for dual AD640 system.
${ }^{12}$ Using the circuit of Figure 24, using single AD640 and offset nulling. Input is sinusoidal, 0 dBm in $50 \Omega=223 \mathrm{mV} \mathrm{rms}$.
${ }^{13}$ Using the circuit of Figure 32, using cascaded AD640s and attenuator. Square wave input.
${ }^{14}$ For outline information see Package Information section.
All min and max specifications are guaranteed, but only those in boldface are $100 \%$ tested on all production units. Results from those tests are used to calculate outgoing quality levels.
Specifications subject to change without notice.

THERMAL CHARACTERISTICS

|  | $\theta_{\mathrm{JC}}\left({ }^{\circ} \mathrm{C} / \mathrm{W}\right)$ | $\theta_{\mathrm{JA}}\left({ }^{\circ} \mathrm{C} / \mathrm{W}\right)$ |
| :--- | :---: | :---: |
| 20-Pin Ceramic DIP Package (D-20) | 25 | 85 |
| 20-Pin Leadless Ceramic Chip Carrier (E-20A) | 25 | 85 |
| 20-Pin Plastic DIP Package (N-20) | 24 | 61 |
| 20-Pin Plastic Leadless Chip Carrier (P-20A) | 28 | 75 |

## ABSOLUTE MAXIMUM RATINGS*

Supply Voltages
. . . . . . . . . . . . . $\pm 7.5 \mathrm{~V}$
Input Voltage (Pin 1 or Pin 20 to COM) . . . . -3 V to +300 mV
Attenuator Input Voltage (Pin 5 to Pin 3/4) . . . . . . . . . . $\pm 4 \mathrm{~V}$
Storage Temperature Range D, E . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Storage Temperature Range N, P . . . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Ambient Temperature Range, Rated Performance
Industrial, AD640B . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Military, AD640T . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Commercial, AD640J . . . . . . . . . . . . . . . . . . 0 to $+70^{\circ} \mathrm{C}$
Lead Temperature Range (Soldering 60sec) . . . . . . . . $+300^{\circ} \mathrm{C}$
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may adversely affect device reliability.

## CONNECTION DIAGRAMS

ORDERING GUIDE

| Model | Temperature Range | Package <br> Description | Package Option ${ }^{*}$ |
| :---: | :---: | :---: | :---: |
| AD640JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Plastic DIP | N-20 |
| AD640JP | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Plastic Leaded Chip Carrier | P-20A |
| AD640BD | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Side Brazed Ceramic DIP | D-20 |
| AD640BE | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Ceramic Leadless Chip Carrier | E-20A |
| AD640BP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Plastic Leaded Chip Carrier | P-20A |
| $\begin{aligned} & \text { AD640TD/883B } \\ & 5962-9095501 M R A \end{aligned}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Side Brazed Ceramic DIP | D-20 |
| AD640TE/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Ceramic Leadless Chip | E-20A |
| 5962-9095501M2A |  | Carrier |  |
| AD640TCHIP | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Chip |  |

*For outline information see Package Information section.


20-Pin PLCC ( $\mathbf{P}$ ) Package



20-Pin LCC (E) Package



Figure 1. AC Response at $30 \mathrm{MHz}, 60 \mathrm{MHz}, 90 \mathrm{MHz}$ and 120 MHz , vs. $d B m$ Input (Sinusoidal Input)


Figure 3. Slope Current, $I_{r}$ vs. Temperature


Figure 2. Logarithmic Response and Linearity at 60 MHz , $T_{A}$ for $T_{A}=-55^{\circ} \mathrm{C},+25^{\circ} \mathrm{C},+125^{\circ} \mathrm{C}$

Figure 4. Intercept Voltage, $V_{x}$, vs. Temperature

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## Selection Tree - Special Function Components



## Selection Guides-Special Function Components

## Frequency Synthesis

|  | Bus Interface <br> Bits | Package <br> Options $^{\mathbf{1}}$ | Temp <br> Ranges $^{2}$ | Page $^{\mathbf{3}}$ | Comments <br> Model |
| :--- | :--- | :--- | :--- | :--- | :--- |
| AD7008 | 8/16, $\boldsymbol{\mu P}$ | S | C $^{4}$ | $21-35$ | DDS IF Modulator with 32-Bit Phase Accumulator and 10-Bit DAC, 20 MHz Output <br> Capability, Single 5 V Supply, Low Power |
| AD9901 |  | E, P, Q | C, M/ | $21-53$ | Ultrahigh Speed Digital Phase/Frequency Discriminator, No "Dead Zone," <br> Linear Transfer Function up to 200 MHz, for PLLs |
| AD9955 | 32, $\boldsymbol{\mu P}$ | S | C | $21-56$ | 85 MHz Direct Digital Synthesizer; 32-Bit Phase Accumulator <br> 12-Bit Sine Output <br> Evaluation Board which contains AD9955 and AD9713B or AD9721 DAC |
| AD9955/PCB |  | Board | C | D |  |

## RF/IF Products

| Model | Function | Max <br> Gain dB | Frequency <br> Range | Package Options ${ }^{1}$ | Temp Ranges ${ }^{2}$ | Page ${ }^{3}$ | Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| AD607 | IF Subsystem Mixer/AGC/RSSI | 109 | 25-450 MHz | RS | I | 21-5 | Monoceiver ${ }^{\text {TM }}$ - Complete Receiver on a Chip |
| AD608 | IF Subsystem Mixer/RSSI | 110 | 5-450 MHz | R | I | 21-9 | +3 V Supply, 90 dB RSSI Range |
| AD831 | Low Distortion Mixer | 0 | 5-500 MHz | P | I | 21-23 | $\pm 5 \mathrm{~V}$ Supply, 24 dBm 3 rd -Order Intercept |

## Special Function Components

|  | Model | Function | Performance | Package Options ${ }^{1}$ | Temp Ranges ${ }^{2}$ | Page ${ }^{3}$ | Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\stackrel{\text { Nin }}{\Delta}$ | AD630 | Balanced Modulator/Demodulator | 2 MHz Bandwidth, Signal Recovery to -100 dB | D, E, $\mathbf{N}$ | C, I, M | 21-13 | Precision Gain $\pm 1$ or $\pm 2$ |
|  | AD720 | RGB to NTSC/PAL Converter | Complete Function with Internal Delay Line | P | C | 21-16 | RGB, Clock In, Luminance, |
|  | AD9500 | ECL Digitally Programmable Delay Generator | 10 ps Resolution, 2.5 ns to $10 \mu \mathrm{~s}$ Full Scale | $\mathbf{E}, \mathbf{P}, \mathbf{Q}$ | I, M | 21-45 | Pulse Deskewing, Phase Control |
|  | Delay Generator |  |  |  |  |  |  |
| $\begin{aligned} & 3 \\ & 2 \\ & 2 \\ & 0 \end{aligned}$ | ${ }^{1}$ Package Options: D = Hermetic DIP, Ceramic or Metal; E = Ceramic Leadless Chip Carrier; F = Ceramic Flatpack; G = Ceramic Pin Grid Array; H = Hermetic Metal Can; J = J-Leaded Ceramic Package; M = Hermetic Metal Can DIP; N = Plastic or Epoxy Sealed DIP; P = Plastic Leaded Chip Carrier; Q = Cerdip; R = Small Outline "SOIC" Package; RS = SSOP-Shrink Small Outline Package; S = Plastic Quad Flatpack; ST = Thin Quad Flatpack; T = TO-92; U = TSOP—Thin Small Outline Package; $\mathrm{W}=$ Nonhermetic Ceramic/Glass DIP; $\mathrm{Y}=$ Single-In-Line "SIP" Package; $\mathrm{Z}=$ Ceramic Leaded Chip Carrier. ${ }^{2}$ Temperature Ranges: $\mathrm{C}=$ Commercial, $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C} ; \mathrm{I}=$ Industrial, $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}\left(\right.$ Some older products $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ); $\mathrm{M}=\mathrm{Military},-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. If a device has military grade offerings, the M temperature designator will be followed by: / to indicate $883 \mathrm{~B},{ }_{\mathrm{J}}$ for JAN, ${ }_{\mathrm{D}}$ for SMD, and ${ }_{\mathrm{s}}$ for space level. <br> ${ }^{3} \mathrm{D}=$ Data Sheet. All other entries refer to this volume. |  |  |  |  |  |  |
|  |  |  |  |  |  |  |  |
|  | Monoceiver is a trademark of Analog Devices, Inc. Boldface Type: Data sheet information in this volume. |  |  |  |  |  |  | Low Power Mixer/AGC/RSSI 3 V Receiver IF Subsystem

## FEATURES

Complete Receiver on a Chip: Monoceiver ${ }^{\text {TM }}$
Interfaces to AD7015 GSM Baseband Converter Mixer
-15 dBm 1 dB Compression Point
> 450 MHz Input Bandwidth

- $\mathbf{1 6}$ dBm LO Input

Linear IF Amplifier
100 dB of Linear-in-dB Gain Control
Internal AGC with RSSI Output or External MGC
Any IF Below $\mathbf{2 5}$ MHz
Quadrature Demodulator
On-Board Phase-Locked Quadrature Oscillator
$90 \pm 1.5^{\circ}$ Phase Quadrature at 10.7 MHz
Can Also Demodulate AM, FM, CW, SSB
Low Power
25 mW at 3 V
CMOS-Compatible Power-Down to $300 \mu \mathbf{W}$
APPLICATIONS
GSM, CDMA, PHP, TDMA Receivers Infrared Data Receivers Battery-Powered Communications Receivers

## GENERAL DESCRIPTION

The AD607 is a 3 V low power receiver RF/IF subsystem for operation at IF or RF input frequencies as high as 450 MHz and IFs to 25 MHz . It consists of a mixer, IF amplifiers, an I/Q demodulator, a phase-locked quadrature oscillator, AGC detector, and a biasing system with external power-down. In a typical DMR application, the AD607 accepts a 240 MHz IF input and downconverts it to a 10.7 MHz IF where it is filtered, amplified with internal AGC (or external MGC), and demodulated into I and $Q$ baseband outputs.
The AD607's low noise, high intercept mixer is a doubly balanced "Gilbert-Cell" type and operates linearly for RF inputs spanning -95 dBm to -15 dBm . It has a nominal -5 dBm thirdorder intercept. The mixer section of the AD607 also includes a local oscillator (LO) preamplifier, which lowers the required LO drive to -16 dBm ( 50 mV sine wave amplitude).
Fully differential access to the RF input increases the versatility of this front end for such applications as interfacing to differential output SAW filters. The mixer's single-sided IF current output can directly drive a bandpass filter with an impedance of $200 \Omega$ or greater. An optional second IF filter can be included to limit wideband noise and provide additional selectivity. The output for the second IF filter can optionally be used to drive an A/D converter or the AD607's PLL, as will be described below.

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## FUNCTIONAL BLOCK DIAGRAM



The gain control input (Pin 12) can serve as either an MGC input or an RSSI (AGC voltage) output. In MGC operation, the AD607 accepts DSP-based MGC input of 0 V to 2 V at pin 12. This voltage can be generated by a DAC in the compatible AD70xx family of baseband converters. In AGC operation, an on-board detector and an external averaging capacitor connected to Pin 12 form an AGC loop that holds the I and Q output levels at about $\pm 300 \mathrm{mV}$. The voltage across this capacitor then provides an RSSI output.
An I/Q demodulator provides in-phase and quadrature baseband outputs to interface with such baseband converters as the Analog Devices' AD7002, AD7005, AD7013, or AD7015. A unique quadrature VCO that is phase-locked to a low level or CMOS-compatible input at the intermediate frequency drives the I and Q demodulator.
The I/Q demodulator can also demodulate AM or FM when its oscillator is phase locked to the received signal; in this mode, the In-Phase and Quadrature demodulators become detectors for $A M$ and FM, respectively. The oscillator can also be phaselocked to an external oscillator and the demodulator will act as a product detector for CW or SSB reception.
The AD607 uses supply voltages from 2.7 V to 6 V over the temperature range of $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. Operation is enabled by a CMOS logical level; response time is typically <3 $\mu \mathrm{s}$. When disabled the standby power is reduced to $300 \mu \mathrm{~W}$. The AD607 comes in a 20 -pin Small-Shrink Outline (SSOP), surface-mount package.

[^267]| Model | Conditions | AD607 |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Ty | Max |  |
| DYNAMIC PERFORMANCE |  |  |  |  |  |
| MIXER <br> RF and LO Frequency Range Conversion Gain Range Voltage Noise Spectral Density Current Noise Spectral Density Nominal RF Input Range Input Third-Order Intercept Input 1 dB Compression Point RF Input Resistance RF Input Capacitance Maximum IF Output Voltage IF Output Bandwidth Mixer LO Drive Level | $0 \leq \mathrm{V}_{\mathrm{G}} \leq 2 \mathrm{~V}, \mathrm{Z}_{\mathrm{L}}=165 \Omega, \mathrm{f}_{\mathrm{RF}}=240 \mathrm{MHz}$ <br> RF Input AC Short Circuited, LO to VP RF Input AC Short Circuited, LO to VP $\begin{aligned} & 0 \leq \mathrm{VG} \leq 2 \mathrm{~V}, \mathrm{f} \leq 1 \mathrm{MHz} \\ & 0 \leq \mathrm{V}_{\mathrm{G}} \leq 2 \mathrm{~V}, \mathrm{f} \leq 450 \mathrm{MHz} \\ & \mathrm{ZIF}=165 \Omega \\ & -3 \mathrm{~dB}, \mathrm{ZIF}=165 \Omega \end{aligned}$ | 450 | $\begin{aligned} & 1.5 \text { to } 26.5 \\ & 2 \\ & \text { TBD } \\ & -95 \text { to }-15 \\ & -5 \\ & -15 \\ & 2.7 \text { to } 5.5 \\ & 2.4 \text { to } 2.75 \\ & 2 \\ & 100 \\ & -16 \end{aligned}$ |  | MHz <br> dB <br> $\mathrm{nV} \sqrt{\mathrm{Hz}}$ <br> $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ <br> dBm <br> dBm <br> dBm <br> $\mathrm{k} \Omega$ <br> pF <br> V p-p <br> MHz <br> dBm |
| IF AMPLIFIERS <br> IF Filter Impedance <br> Bandwidth <br> Gain Range | $\begin{aligned} & \text { (For Example, Murata SFE10.7) } \\ & -3 \mathrm{~dB} \\ & 0 \leq \mathrm{V}_{\mathrm{G}} \leq 2 \mathrm{~V} \end{aligned}$ | 200 | $\begin{aligned} & 330 \\ & 50 \\ & 7.5 \text { to } 82.5 \end{aligned}$ |  | $\begin{aligned} & \Omega \\ & \mathrm{MHz} \\ & \mathrm{~dB} \end{aligned}$ |
| GAIN CONTROL <br> Overall Gain Range <br> Gain Scaling <br> Gain Error <br> Bias Current at GAIN (Pin 12) Bias Current at GREF (Pin 7) <br> Resistance at GAIN, GREF | Mixer + IF Section, $0 \leq \mathrm{V}_{\mathrm{G}} \leq 2 \mathrm{~V}, \mathrm{GREF}$ Connected to 1.5 V <br> GREF Connected to 1.5 V <br> GREF Connected to General Reference Voltage $\mathrm{V}_{\mathrm{R}}$ $0 \leq \mathrm{V}_{\mathrm{G}} \leq 2 \mathrm{~V}$, GREF Connected to 1.5 V |  |  |  | dB <br> $\mathrm{dB} / \mathrm{V}$ <br> $\mathrm{dB} / \mathrm{V}$ <br> dB <br> $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ <br> $\mathrm{M} \Omega$ |
| I AND Q DEMODULATORS <br> Input Resistance Input Bias Current Demodulation Gain Maximum Output Voltage Demodulation Nonlinearity Output Bandwidth | From DMIP to VMID <br> Sine Wave Input, Baseband Output $\mathrm{R}_{\mathrm{L}} \geq 10 \mathrm{k} \Omega$ <br> Full Output Voltage <br> Sine Wave Input, Baseband Output |  | $\begin{aligned} & >50 \\ & 1 \\ & 18 \\ & 2.5 \\ & 0.1 \\ & 3 \end{aligned}$ |  | k $\Omega$ <br> $\mu \mathrm{A}$ <br> dB <br> V p-p <br> \% <br> MHz |
| CARRIER-RECOVERY PLL <br> Frequency Range <br> Required Input Drive Level <br> Quadrature Error <br> Acquisition Time to $\pm 3^{\circ}$ | Sine Wave Input at Pin 1 $\begin{aligned} & \mathrm{IF}=10.7 \mathrm{MHz} \\ & \mathrm{IF}=10.7 \mathrm{MHz} \end{aligned}$ |  | $\begin{aligned} & 0.4 \text { to } 25 \\ & 200 \\ & \pm 1.5 \\ & <10 \end{aligned}$ |  | MHz <br> mV p-p <br> Degree <br> $\mu \mathrm{s}$ |
| POWER-DOWN INTERFACE Logical Threshold Input Current for Logical High Turn-On Response Time Turn-Off Response Time Standby Current | To $200 \mu \mathrm{~A}$ Supply Current |  | $\begin{aligned} & 1.5 \\ & 75 \\ & 500 \\ & 1 \\ & 100 \end{aligned}$ |  | V dc $\mu \mathrm{A}$ <br> ns $\mu \mathrm{s}$ $\mu \mathrm{A}$ |
| POWER SUPPLY Supply Range Supply Current | Mid-Gain, $\mathrm{IF}=10.7 \mathrm{MHz}$ | 2.7 | $\begin{aligned} & 3 \\ & 8 \end{aligned}$ | 6 | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~mA} \end{aligned}$ |
| OPERATING TEMPERATURE $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |  | -25 |  | +85 | ${ }^{\circ} \mathrm{C}$ |

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## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$



## PIN CONNECTION

## 20-Lead SSOP



## PIN DESCRIPTION

| Pin | Mnemonic | Reads | Function |
| :---: | :---: | :---: | :---: |
| 1 | FDIN | Frequency Demodulator Input | PLL input for I /Q demodulator quadrature oscillator. |
| 2 | COM1 | Common \#1 | Supply common for RF front end and main bias. |
| 3 | PRUP | Power-Up | 3. V/5 V CMOS-compatible power-up control. |
| 4 | LOIP | Local Oscillator Input | LO external input. |
| 5 | RFLO | RF "Low" Input | Usually connected to ac ground. |
| 6 | RFHI | RF "High" Input \% \% \% | Accepts RF input of -95 dBm to -15 dBm . |
| 7 | GREF | Gain Reference | High impedance input, typically 1.5 V , sets gain scaling. |
| 8 | MXOP | Mixer Output \% | Low impedance, single-sided voltage output, +5 dBm max. |
| 9 | VMID | Mid-Supply Bias Voltage Output | Output of the mid-supply bias generator (VPOS/2). |
| 10 | IFHI | IF "High" Input 素 | ${ }^{\text {IF }}$ F input, $+5 \mathrm{dBm}( \pm 56 \mathrm{mV})$ max. |
| 11 | IFLO | IF "Low", Voltage | Reference node for IF input; auto-offset null. |
| 12 | GAIN | Gain Control Input | High impedance input, $0 \mathrm{~V}-2 \mathrm{~V}$, max gain at $\mathrm{V}=0$. |
| 13 | COM2 | Common \#2 | Supply common for IF stages and demodulator. |
| 14 | IFOP | IF Output | Low impedance, single-sided voltage output, +5 dBm max. |
| 15 | DMIP | Demodulator Input | Signal input to I and Q demodulators. |
| 16 | VPS2 | VPOS Supply \#2 | Supply to high level IF, PLL, and demodulators. |
| 17 | QOUT | Quadrature Output | Low impedance Q baseband output, $\pm 1.23 \mathrm{~V}$ full scale. |
| 18 | IOUT | In-Phase Output | Low impedance I baseband output, $\pm 1.23 \mathrm{~V}$ full scale. |
| 19 | FLTR | PLL Loop Filter | Series RC PLL Loop filter connected to ground. |
| 20 | VPS1 | VPOS Supply \#1 | Supply to mixer, low level IF, PLL, and gain control. |

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD607 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

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## AD607



Figure 1. AD607 Functional Block Diagram


Figure 2. AD607 Connections to AD7015 Baseband Converter. The AUX DAC Output from the AD7015 Controls the Gain in the AD607


Figure 3. AD607 Connections for AM or FM Demodulation. The PLL Recovers the Received Carrier via the Connection (Darker Line) Between Pins 1 and 15. The AD607's Internal AGC Circuit Controls the Gain and Provides an RSSI Output at Pin 12

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## FEATURES

## Mixer

-15 dBm, 1 dB Compression Point
-5 dBm IP3
26 dB Conversion Gain
>450 MHz Input Bandwidth
Logarithmic/Limiting Amplifier
90 dB RSSI Range
$\pm 3^{\circ}$ Phase Stability over $\mathbf{8 0} \mathrm{dB}$ Range
Low Power
21 mW at 3 V Power Consumption
CMOS-Compatible Power-Down to $200 \mu \mathrm{~W}$ typ
150 ns Enable/Disable Time

## APPLICATIONS

Low Power PHP, GSM, TDMA, FM, or PM Receivers Battery-Powered Instrumentation

## GENERAL DESCRIPTION

The AD608 provides both a low power, low distortion, low noise mixer and a complete, monolithic logarithmic/limiting amplifier using a "successive-detection" technique. It provides both a high speed RSSI (Received Signal Strength Indicator) output with 90 dB dynamic range and a hard-limited output. The RSSI output is from a two-pole post demodulation lowpass filter and provides a loadable output voltage of +0.2 V to +2 V . The AD608 operates from a single 2.7 V to 6 V supply at a typical power level of 21 mW at 3 V .

The RF and LO bandwidths both exceed 450 MHz . In a typical IF application, the AD608 will accept the output of a 240 MHz SAW filter and downconvert it to a nominal 10.7 MHz IF with a conversion gain of $26 \mathrm{~dB}\left(\mathrm{Z}_{\mathrm{IF}}=165 \Omega\right)$. The AD608's logarithmic/limiting amplifier section handles any IF from LF to as high as 50 MHz .
The mixer is a doubly balanced "Gilbert-Cell" type and operates linearly for RF inputs spanning -95 dBm to -15 dBm . It has a nominal -5 dBm third-order intercept. An on-board LO preamplifier requires only -6 dBm of LO drive. The mixer's current output drives a reverse-terminated, industry-standard $10.7 \mathrm{MHz}, 330 \Omega$ filter and can drive reverse-terminated filter impedances as low as $220 \Omega$.
The nominal logarithmic scaling is such that the output is +0.2 V for a sinusoidal input of -75 dBm and +2.0 V at an input of +15 dBm , over this range the logarithmic conformance is typically $\pm 1 \mathrm{~dB}$. The logarithmic slope is proportional to the supply voltage. A feedback loop automatically nulls the input offset of the first stage down to the submicrovolt level.
The AD608's limiter output provides a hard-limited signal output at 400 mV p-p. The voltage gain of the limiting amplifier to this output is more than 100 dB . Transition times are 7 ns , and the phase is stable to within $\pm 3^{\circ}$ at 10.7 MHz for signals from -75 dBm to +15 dBm .
It is enabled by a CMOS logic-level voltage input, with a response time of 150 ns . When disabled, the standby power is reduced to $200 \mu \mathrm{~W}$ within 400 ns .
The AD608 is specified for the industrial temperature range of $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ and is available in 16 -pin plastic SOICs.

## FUNCTIONAL BLOCK DIAGRAM



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| Parameter | Conditions | Min | $\begin{aligned} & \text { AD60 } \\ & \text { Typ } \end{aligned}$ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| MIXER PERFORMANCE <br> Conversion Gain Input Referred Noise Equivalent Noise Resistance Third-Order Intercept Input Resistance Input Capacitance | $\mathrm{f}_{\mathrm{RF}}=240 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=229.3 \mathrm{MHz}$ <br> Doubly Terminated $330 \Omega$ IF Filter AC Short-Circuited Input |  | $\begin{aligned} & 2.5 \\ & 375 \\ & -5 \\ & 4 \\ & 3 \end{aligned}$ | 26 | dB <br> $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ <br> $\Omega$ <br> dBm <br> k $\Omega$ <br> pF |
| LIMITER PERFORMANCE <br> Gain <br> Input Referred Noise <br> Input Resistance <br> Input Capacitance <br> Phase Variation <br> DC Level <br> Output Level <br> Rise and Fall Times | Full Temperature and Supply Range AC Short-Circuited Input <br> -75 dBm to +15 dBm Input Signal at 10.7 MHz Center of Output Swing (VPOS-1) <br> Driving a 5 pF Load | $100$ | $\begin{aligned} & 110 \\ & 1.75 \\ & 10 \\ & 2 \\ & \pm 3 \\ & 2 \\ & 400 \\ & 7 \end{aligned}$ |  | $\begin{aligned} & \mathrm{nV} / \sqrt{\mathrm{Hz}} \\ & \mathrm{k} \Omega \\ & \mathrm{pF} \\ & \text { Degree } \\ & \mathrm{V} \\ & \mathrm{mV} \text { p-p } \\ & \mathrm{ns} \end{aligned}$ |
| RSSI PERFORMANCE <br> Nominal Slope Nominal Intercept Minimum RSSI Voltage Maximum RSSI Voltage Logarithmic Linearity Error RSSI Response Time Output Impedance | At 10.7 MHz <br> Proportional to VPOS <br> -75 dBm Input Signal <br> +15 dBm Input Signal <br> -75 dBm to +15 dBm Input Signal <br> $10 \%$ to $90 \%$ <br> At Midscale | , | $\begin{aligned} & 20 \\ & -85 \\ & 0.2 \\ & 2.0 \\ & \pm 1 \\ & 200 \\ & 250 \end{aligned}$ |  | $\mathrm{mV} / \mathrm{dB}$ dBm V V dB ns $\Omega$ |
| POWER-DOWN INTERFACE <br> Logical Threshold <br> Input Current <br> Power-Up Response Time <br> Power-Down Response Time <br> Power-Down Current | System Active on Logical High <br> For Logical High Active Limiter Output To $200 \mu \mathrm{~A}$ Supply Current |  | $\begin{aligned} & 1.5 \\ & 75 \\ & 150 \\ & 400 \\ & 100 \end{aligned}$ |  | V <br> $\mu \mathrm{A}$ <br> ns <br> ns <br> $\mu \mathrm{A}$ |
| POWER SUPPLY Operating Range Powered Up Current | VPOS $=3 \mathrm{~V}$ | 2.7 | $7.3$ | 6 | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~mA} \end{aligned}$ |
| OPERATING TEMPERATURE $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\mathrm{MAX}}$ |  | -25 |  | +85 | ${ }^{\circ} \mathrm{C}$ |

Specifications subject to change without notice.

ABSOLUTE MAXIMUM RATINGS ${ }^{1}$
Supply Voltage VPOS . . . . . . . . . . . . . . . . . . . . . . . . . . . . 6 V
Internal Power Dissipation ${ }^{2}$. . . . . . . . . . . . . . . . . . . . 600 mW
Operating Temperature Range . . . . . . . . . . . . $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature, Soldering ( 60 sec ) . . . . . . . . . . . . . $+300^{\circ} \mathrm{C}$ NOTES
${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended rating conditions for extended periods may affect device reliability.
${ }^{2}$ Thermal Characteristics: 16 -pin SOIC package; $\theta_{J A}=$ TBD.

ORDERING GUIDE

| Model | Temperature Range | Package Option ${ }^{\star}$ |
| :--- | :--- | :--- |
| AD608AR | $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $16-$ Pin Narrow-Body <br> SOIC (R-16A) |

*For outline information see Package Information section.

## PIN DESIGNATIONS



## PIN DESCRIPTION

| Pin | Mnemonic | Description |
| :---: | :--- | :--- |
| 1 | VPS1 | Positive Supply Input |
| 2 | COM1 | Common |
| 3 | LOHI | Local Oscillator Input Connection |
| 4 | COM2 | Common |
| 5 | RFH | RF Input, Noninverting |
| 6 | RFLO | RF Input, Inverting |
| 8 | MXOP | Mixer Output |
| 8 | IFBS | Midpoint Supply Bias Output |
| 9 | IFHI | IF Input, Noninverting |
| 10 | IFLO | IF Input, Inverting |
| 11 | RSSI | Received Signal Strength Indicator Output |
| 12 | COM3 | Output Common |
| 13 | FDBK | Feedback Loop Output |
| 14 | VPS2 | Limiter Positive Supply Input |
| 15 | LMOP | Limiter Output |
| 16 | PRUP | Power-Up |

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD608 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.


Figure 1. AD608 Functional Block Diagram


Figure 2. AD608 Application Circuit

This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.
FEATURES
Recovers Signal from +100 dB Noise
2MHz Channel Bandwidth 45V/ $\mu \mathrm{s}$ Slew Rate
-120dB Crosstalk @ 1kHz
Pin Programmable Closed Loop Gains of $\pm 1$ and $\pm 2$ 0.05\% Closed Loop Gain Accuracy and Match
$100 \mu \mathrm{~V}$ Channel Offset Voltage (AD630BD) 350kHz Full Power Bandwidth Chips Available

## PRODUCT DESCRIPTION

The AD630 is a high precision balanced modulator which combines a flexible commutating architecture with the accuracy and temperature stability afforded by laser wafer trimmed thin film resistors. Its signal processing applications include balanced modulation and demodulation, synchronous detection, phase detection, quadrature detection, phase sensitive detection, lock-in amplification and square wave multiplication. A network of onboard applications resistors provides precision closed loop gains of $\pm 1$ and $\pm 2$ with $0.05 \%$ accuracy (AD630B). These resistors may also be used to accurately configure multiplexer gains of $+1,+2,+3$ or +4 . Alternatively, external feedback may be employed allowing the designer to implement his own high gain or complex switched feedback topologies.
The AD630 may be thought of as a precision op amp with two independent differential input stages and a precision comparator which is used to select the active front end. The rapid response time of this comparator coupled with the high slew rate and fast settling of the linear amplifiers minimize switching distortion. In addition, the AD630 has extremely low crosstalk between channels of $-100 \mathrm{~dB} @ 10 \mathrm{kHz}$.
The AD630 is intended for use in precision signal processing and instrumentation applications requiring wide dynamic range. When used as a synchronous demodulator in a lock-in amplifier configuration, it can recover a small signal from 100 dB of interfering noise (see lock-in amplifier application). Although optimized for operation up to 1 kHz , the circuit is useful at frequencies up to several hundred kilohertz.
Other features of the AD630 include pin programmable frequency compensation, optional input bias current compensation resistors, common mode and differential offset voltage adjustment, and a channel status output which indicates which of the two differential inputs is active. This device is now available to Standard Military Drawing (DESC) numbers 5962-8980701RA and 5962-89807012A.


## PRODUCT HIGHLIGHTS

1. The configuration of the AD630 makes it ideal for signal processing applications such as: balanced modulation and demodulation, lock-in amplification, phase detection, and square wave multiplication.
2. The application flexibility of the AD630 makes it the best choice for many applications requiring precisely fixed gain, switched gain, multiplexing, integrating-switching functions, and high-speed precision amplification.
3. The 100 dB dynamic range of the AD630 exceeds that of any hybrid or IC balanced modulator/demodulator and is comparable to that of costly signal processing instruments.
4. The op-amp format of the AD630 ensures easy implementation of high gain or complex switched feedback functions. The application resistors facilitate the implementation of most common applications with no additional parts.
5. The AD630 can be used as a two channel multiplexer with gains of $+1,+2,+3$ or +4 . The channel separation of $100 \mathrm{~dB} @ 10 \mathrm{kHz}$ approaches the limit which is achievable with an empty IC package.
6. The AD630 has pin-strappable frequency compensation (no external capacitor required) for stable operation at unity gain without sacrificing dynamic performance at higher gains.
7. Laser trimming of comparator and amplifying channel offsets eliminates the need for external nulling in most cases.
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## AD630-SPECIFICATIONS <br> (@ $+25^{\circ} \mathrm{C}$ and $\pm \mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}$ unless otherwise noted)

| Model | AD630J/A |  |  | AD630K/B |  |  | AD630S |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| GAIN <br> Open Loop Gain $\pm 1, \pm 2$ Closed Loop Gain Error Closed Loop Gain Match Closed Loop Gain Drift | 90 | $\begin{aligned} & 110 \\ & 0.1 \\ & 0.1 \\ & 2 \end{aligned}$ |  | 100 | $120$ $2$ | $\begin{aligned} & 0.05 \\ & 0.05 \end{aligned}$ | 90 | $\begin{aligned} & 110 \\ & 0.1 \\ & 0.1 \\ & 2 \end{aligned}$ |  | $\begin{aligned} & \mathrm{dB} \\ & \% \\ & \% \\ & \mathrm{ppm}^{\circ} \mathrm{C} \\ & \hline \end{aligned}$ |
| CHANNEL INPUTS <br> $\mathrm{V}_{\text {IN }}$ Operational Limit ${ }^{1}$ Input Offset Voltage Input Offset Voltage $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}{ }^{2}$ <br> Input Bias Current Input Offset Current Channel Separation@10kHz | $(-V$ | $4 \mathrm{~V}) \text { to }$ <br> 100 <br> 10 <br> 100 | $\begin{aligned} & s-1 V) \\ & 500 \\ & \\ & \mathbf{8 0 0} \\ & \mathbf{3 0 0} \\ & \mathbf{5 0} \end{aligned}$ | $(-\mathrm{V}$ | V) to <br> 100 <br> 10 <br> 100 | $\begin{aligned} & s-1 V) \\ & 100 \\ & \\ & 160 \\ & 300 \\ & \mathbf{5 0} \end{aligned}$ | (-V | FV) to <br> 100 <br> 10 <br> 100 | $\begin{aligned} & -1 V) \\ & \mathbf{5 0 0} \\ & \\ & \mathbf{1 0 0 0} \\ & \mathbf{3 0 0} \\ & \mathbf{5 0} \end{aligned}$ | Volts <br> $\mu \mathrm{V}$ <br> $\mu \mathrm{V}$ <br> nA <br> nA <br> dB |
| COMPARATOR <br> $\mathrm{V}_{\text {IN }}$ Operational Limit ${ }^{1}$ <br> Switching Window <br> Switching Window $\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\text {max }}{ }^{2}$ <br> Input Bias Current <br> Response Time ( -5 mV to +5 mV step) <br> Channel Status $\mathrm{I}_{\mathrm{SINK}} @ \mathrm{~V}_{\mathrm{OL}}=-\mathrm{V}_{\mathrm{S}}+0.4 \mathrm{~V}^{3}$ <br> Pull-Up Voltage | $(-V$ $1.6$ | $3 V) \text { to }$ $\begin{aligned} & 100 \\ & 200 \end{aligned}$ | $\begin{gathered} s-1.5 \mathrm{~V}) \\ \pm 1.5 \\ \\ \pm 2.0 \\ 300 \end{gathered}$ $\left(-V_{S}+33 \mathrm{~V}\right)$ | $(-\mathrm{V}$ $1.6$ | V) to $100$ $200$ | $\begin{aligned} & s-1.5 \mathrm{~V}) \\ & \pm 1.5 \\ & \pm 2.0 \\ & \mathbf{3 0 0} \end{aligned}$ $\left(-V_{S}+33 \mathrm{~V}\right)$ | $(-\mathrm{V}$ $1.6$ | $3 \mathrm{~V}) \text { to }$ $\begin{aligned} & 100 \\ & 200 \end{aligned}$ | $\begin{aligned} & -1.3 \mathrm{~V}) \\ & \pm 1.5 \\ & \pm 2.5 \\ & 300 \end{aligned}$ $\left(-V_{S}+33 \mathrm{~V}\right)$ | Volts mV <br> mV <br> nA <br> ns <br> mA <br> Volts |
| DYNAMIC PERFORMANCE <br> Unity Gain Bandwidth <br> Slew Rate ${ }^{4}$ <br> Settling Time to $0.1 \%$ ( 20 V step) |  | $\begin{aligned} & 2 \\ & 45 \\ & 3 \end{aligned}$ |  |  | $\begin{aligned} & 2 \\ & 45 \\ & 3 \end{aligned}$ |  |  | $\begin{aligned} & 2 \\ & 45 \\ & 3 \\ & \hline \end{aligned}$ |  | MHz <br> V/ $\mu \mathrm{s}$ <br> $\mu \mathrm{s}$ |
| OPERATING CHARACTERISTICS <br> Common-Mode Rejection <br> Power Supply Rejection <br> Supply Voltage. Range <br> Supply Current | $\begin{aligned} & 85 \\ & 90 \\ & \pm 5 \end{aligned}$ | $\begin{aligned} & 105 \\ & 110 \\ & 4 \end{aligned}$ | $\begin{aligned} & \pm 16.5 \\ & 5 \end{aligned}$ | $\begin{aligned} & 90 \\ & 90 \\ & \pm 5 \end{aligned}$ | $\begin{aligned} & 110 \\ & 110 \\ & 4 \end{aligned}$ | $\pm 16.5$ | $\begin{aligned} & 90 \\ & 90 \\ & \pm 5 \end{aligned}$ | $\begin{aligned} & 110 \\ & 110 \\ & 4 \end{aligned}$ | $\begin{aligned} & \pm 16.5 \\ & 5 \end{aligned}$ | dB <br> dB <br> Volts <br> mA |
| $\begin{aligned} & \text { OUTPUT VOLTAGE, }\left(\omega \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega\right. \\ & \mathrm{T}_{\min } \text { to } \mathrm{T}_{\max }^{2} \\ & \text { Outpuit Short Circuit Current } \end{aligned}$ | $\pm 10$ | 25 |  | $\pm 10$ | 25 |  | $\pm 10$ |  |  | Volts mA |
| TEMPERATURERANGES Rated Performance-N Package D Package | $\begin{aligned} & 0 \\ & -25 \end{aligned}$ |  | $\begin{aligned} & +70 \\ & +85 \end{aligned}$ | $\begin{aligned} & 0 \\ & -25 \end{aligned}$ |  | $\begin{aligned} & +70 \\ & +85 \end{aligned}$ | -55 | N/A | + 125 | $\begin{aligned} & { }^{\circ} \mathrm{C} \\ & { }^{\circ} \mathrm{C} \end{aligned}$ |

## NOTES

${ }^{1}$ If one terminal of each differential channel or comparator input is kept within these limits the other terminal may be taken to the positive supply.
${ }^{2}$ These parameters are guaranteed but not tested for J and K grades. For $\mathrm{A}, \mathrm{B}$ and S grades they are tested.
${ }^{3} \mathrm{I}_{\text {IINK }}\left(a \mathrm{~V}_{\mathrm{OL}}=\left(-\mathrm{V}_{\mathrm{S}}+1\right)\right.$ volt is typically 4 mA .
${ }^{4}$ Pin 12 Open. Slew rate with Pins $12 \& 13$ shorted is typically $35 \mathrm{~V} / \mu \mathrm{s}$.
Specifications subject to change without notice.
Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All $\min$ and max specifications are guaranteed, although only those shown in boldface are tested on all production units.

## ABSOLUTE MAXIMUM RATINGS

Supply Voltage . . . . . . . . . . . . . . . . . . . . . $\pm 18 \mathrm{~V}$
Internal Power Dissipation 600 mW
Output Short Circuit to Ground Indefinite
Storage Temperature, Ceramic Package . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Storage Temperature, Plastic Package . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Lead Temperature, 10 sec. Soldering . . . . . . . . . $+300^{\circ} \mathrm{C}$
Max Junction Temperature . . . . . . . . . . . . . . $+150^{\circ} \mathrm{C}$

THERMAL CHARACTERISTICS

|  | $\theta_{\mathbf{J C}}$ | $\theta_{\mathbf{J A}}$ |
| :--- | :--- | :--- |
| 20-Pin Plastic DIP(N) | $24^{\circ} \mathrm{C} / \mathrm{W}$ | $61^{\circ} \mathrm{C} / \mathrm{W}$ |
| 20-Pin Ceramic DIP(D) | $35^{\circ} \mathrm{C} / \mathrm{W}$ | $120^{\circ} \mathrm{C} / \mathrm{W}$ |
| 20-Pin Leadless Chip |  |  |
| $\quad$ Carrier (E) | $35^{\circ} \mathrm{C} / \mathrm{W}$ | $120^{\circ} \mathrm{C} / \mathrm{W}$ |

CHIP METALIZATION AND PINOUT
Dimensions shown in inches and (mm).
Contact factory for latest dimensions


## CHIP AVAILABILITY

The AD630 is available in laser trimmed, passivated chip form. The figure shows the AD630 metalization pattern, bonding pads and dimensions. AD630 chips are available; consult factory for details.

## PIN CONFIGURATIONS

20-Pin Plastic DIP (N-20) 20-Pin Side Brazed DIP (D-20)


20-Contact LCC (E-20A)


ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD630JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Plastic DIP | $\mathrm{N}-20$ |
| AD630KN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Plastic DIP | $\mathrm{N}-20$ |
| AD630AD | $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Side Brazed DIP | $\mathrm{D}-20$ |
| AD630BD | $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Side Brazed DIP | $\mathrm{D}-20$ |
| AD630SD | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Side Brazed DIP | $\mathrm{D}-20$ |
| AD630SD/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Side Brazed DIP | $\mathrm{D}-20$ |
| 5962-8980701RA | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Side Brazed DIP | $\mathrm{D}-20$ |
| AD630SE/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | LCC | E-20A |
| 5962-89807012A | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | LCC | E-20A |
| AD630J Chip | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Chip |  |
| AD630S Chip | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Chip |  |

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## FEATURES

## Composite Video Output

Chrominance and Luminance (S-Video) Outputs
No External Filters or Delay Lines Required
Drives $75 \Omega$ Reverse-Terminated Loads

## Compact 28-Pin PLCC

Logic Selectable NTSC or PAL Encoding Modes
Automatically Selects Proper Chrominance Filter Cutoff Frequency for Encoding Standard
Logic Selectable Encode or Power-Down Mode (AD720 Only)
Logic Selectable Encode or Bypass Mode (AD721 Only) Low Power: $\mathbf{2 0 0 ~ m W ~ t y p i c a l ~}$

APPLICATIONS<br>RGB to NTSC or PAL Encoding<br>Drive RGB Signals into $75 \Omega$ Load (AD721 Only)

## PRODUCT DESCRIPTION

The AD720 and AD721 RGB to NTSC/PAL Encoders convert red, green and blue color component signals into their corresponding luminance (baseband amplitude) and chrominance (subcarrier amplitude and phase) signals in accordance with either NTSC or PAL standards. These two outputs are also combined to provide a composite video output. All three outputs are available separately at voltages of twice the standard signal levels as required for driving $75 \Omega$ reverse terminated cables. The AD721 also features a bypass mode, in which the RGB inputs may bypass the encoder section of the IC via three gain-of-two amplifiers suitable for driving $75 \Omega$ reverse terminated cables.

The AD720 and AD721 provide a complete, fully calibrated function, requiring only termination resistors, bypass capacitors, a clock input at four times the subcarrier frequency, and a composite sync pulse. There are two control inputs: one input selects the TV standard (NTSC/PAL) and the other (ENCD) powers down most sections of the chip when the encoding function is not in use (AD720) or activates the triple bypass buffer to drive the RGB signals when RGB encoding is not required (AD721). All logical inputs are CMOS compatible. The chip operates from $\pm 5 \mathrm{~V}$ supplies.
All required low-pass filters are on chip. After the input signals pass through a precision RGB to YUV encoding matrix, two onchip low-pass filters limit the bandwidth of the $U$ and $V$ color difference signals to 1.2 MHz prior to quadrature modulation of the color subcarrier; a third low-pass filter at 3.6 MHz (NTSC) or 4.4 MHz (PAL) follows the modulators to limit the harmonic content of the output.
Delays in the U and V chroma filters are matched by an on-chip sampled data delay line in the Y signal path; to prevent aliasing, prefilter at 5 MHz is included ahead of the delay line and a post filter at 5 MHz is added after the delay line to suppress harmonics in the output. These low-pass filters are optimized for minimum pulse overshoot. The overall delay is about 170 ns , which precompensates for delays in the filters used to decode the NTSC or PAL signal in a television receiver. (This precompensation delay is already present in TV broadcasts.)
The AD720 and AD721 are available in a 28 -pin plastic leaded chip carrier for the $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ commercial temperature range.



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## ABSOLUTE MAXIMUM RATINGS*

Supply Voltage $\pm \mathrm{V}_{\text {S }}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 6$ V
Internal Power Dissipation . . . . . . . . . . . . . . . . . . . . . . . 600 mW Operating Temperature Range . . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature, Soldering 60 sec . . . . . . . . . . . . . . $+300^{\circ} \mathrm{C}$ NOTE
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended rating conditions for extended periods may affect device reliability.
Thermal characteristics: 28-pin plastic package: $\theta_{\mathrm{JA}}=100^{\circ} \mathrm{C}$.
ORDERING GUIDE

| Model | Temperature <br> Range | Package | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD720JP | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 28-Pin PLCC | P-28A |
| AD721JP | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 28-Pin PLCC | P-28A |

*For outline information see Package Information section.
PIN CONNECTIONS
28-Lead Plastic Leaded Chip Carrier (PLCC) Package


NOTE:
CONNECTIONS IN () PERTAIN ONLY TO AD720

## PIN DESCRIPTIONS

| Pin | Mnemonic* | Description* |
| :---: | :---: | :---: |
| 1 | (NC) GOUT | (No Connection) Green Bypass Buffer |
| 2 | (NC) APOS | (No Connection) Analog Positive Supply; +5V $\pm 5 \%$ |
| 3 | (NC) ROUT | (No Connection) Red Bypass Buffer |
| 4 | AGND | Analog Ground Connection |
| 5 | ENCD | A Logical High Enables the NTSC/PAL Encode Mode (A Logical Low Powers Down the Chip) A Logical Low Enables the RGB Bypass Mode |
| 6 | RDIN | Red Component Video Input 0 mV to 714 mV for NTSC 0 mV to 700 mV for PAL |
| 7 | AGND | Analog Ground Connection |
| 8 | GRIN | Green Component Video Input 0 mV to 714 mV for NTSC 0 mV to 700 mV for PAL |
| 9 | AGND | Analog Ground Connection |
| 10 | BLIN | Blue Component Video Input 0 mV to 714 mV for NTSC 0 mV to 700 mV for PAL |
| 11 | STND | A Logical High Input Selects NTSC Encoding A Logical Low Input Selects PAL Encoding CMOS Logic Levels |
| 12 | AGND | Analog Ground Connection |
| 13 | CRMA | Chrominance Output; Subcarrier Only ${ }^{\star \star}$ 572 mV Peak-to-Peak for NTSC 600 mV Peak-to-Peak for PAL |
| 14 | APOS | Analog Positive Supply; +5 V $\pm 5 \%$ |
| 15 | CMPS | Composite Video Output** -572 mV to 2 V for NTSC -600 mV to 2 V for PAL |
| 16 | APOS | Analog Positive Supply; $+5 \mathrm{~V} \pm 5 \%$ |
| 17 | LUMA | Luminance Plus SYNC Output** -572 mV to 1.43 V for NTSC -600 mV to 1.4 V for PAL |
| 18 | VNEG | System Negative Supply; $-5 \mathrm{~V} \pm 5 \%$ |
| 19 | DGND | Digital Ground Connection |
| 20 | 4FSC | Clock Input at Four Times the Subcarrier Frequency <br> 14.318180 MHz for NTSC <br> 17.734480 MHz for PAL <br> CMOS Logic Levels |
| 21 | DPOS | Digital Positive Supply; +5V $\pm 5 \%$ |
| 22 | ASNC | A Logical High Input Resets the Subcarrier Phase Every Frame <br> A Logical Low Input Resets the Subcarrier Phase Every Fourth Frame CMOS Logic Levels |
| 23 | DPOS | Digital Positive Supply; +5V $\pm 5 \%$ |
| 24 | SYNC | Input for Composite Television Synchronization Pulses Negative Sync Pulses CMOS Logic Levels |
| 25 | DGND | Digital Ground Connections (One of Two) |
| 26 | VNEG | System Negative Supply; $-5 \mathrm{~V} \pm 5 \%$ |
| 27 | (NC) BOUT | (No Connection) Blue Bypass Buffer |
| 28 | APOS | Analog Positive Supply; +5V $\pm 5 \%$ |

*() pertain only to AD720.
**The luminance, chrominance, and composite outputs are at twice normal levels for driving $75 \Omega$ reverse-terminated lines.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD720/AD721 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


# Typical Characteristics-AD720/AD721 



Figure 1. AD720/AD721 Evaluation Setup


Figure 2. Composite Output Differential Phase and Gain, NTSC (Nulled to Chroma Output)


Figure 3. Modulated Pulse and Bar, NTSC


Figure 4. $100 \%$ Color Bars, NTSC


Figure 5. Multipulse, NTSC


Figure 6. Horizontal Timing, NTSC


Figure 7. Horizontal Timing, PAL

## AD720/AD721

## THEORY OF OPERATION

Referring to the AD720/AD721 block diagram (Figure 8), the RGB inputs (each 0 mV to 714 mV in NTSC or 0 mV to 700 mV in PAL) are first encoded into luminance and color difference signals. The luminance signal is called the " Y " signal and the color-difference signals are called U and V . The RGB inputs are encoded into the YUV format using the transformation

$$
\begin{aligned}
& \mathrm{Y}=0.299 \mathrm{R}+0.587 \mathrm{G}+0.114 \mathrm{~B} \\
& \mathrm{U}=0.493(\mathrm{~B}-\mathrm{Y}) \\
& \mathrm{V}=0.877(\mathrm{R}-\mathrm{Y})
\end{aligned}
$$

For NTSC operation, the chroma amplitude is increased by the factor 1.06 prior to summation with the luminance output. The burst signal is inserted into the $Y$ channel in the encoding matrix.
The three outputs of the encoding matrix, now transformed into Y , U , and V components, take two paths. The Y (luminance) signal is passed through a delay line consisting of a prefilter, a sampled-data delay line, and a post filter. The pre- and post-filters prevent aliasing of harmonics back into the baseband video. The overall delay is a nominal -170 ns relative to the chrominance signal, in keeping with broadcast requirements to compensate for delays introduced by the filters in the decoding process.
The U and V components pass through 4-pole modified Bessel low-pass filters with a $1.2 \mathrm{MHz}-3 \mathrm{~dB}$ frequency to prevent aliasing in the balanced modulators, where they modulate a 3.579545000 MHz (NTSC) or 4.433618750 MHz (PAL) signal via a pair of balanced modulators driven in quadrature by the color subcarrier.

The AD720/AD721 4FSC input drives a digital divide-by-4 circuit (two flip-flops) to create the quadrature signal. The reference phase $0^{\circ}$ is used for the $U$ signal. In the NTSC mode, the V signal is modulated at $90^{\circ}$, but in the PAL mode, the V modulation input alternates between $90^{\circ}$ and $270^{\circ}$ at half the line rate as required by the PAL standard. The outputs of the balanced modulators are summed and low-pass filtered to remove harmonics.
The filtered output is summed with the luminance signal to create a composite video signal. The separate luminance, chrominance, and composite video signals are amplified by gain-of-two amplifiers for driving $75 \Omega$ reverse-terminated lines. The separate luminance and chrominance outputs together are known as "S-Video."

The digital section of the AD720/AD721 is clocked by the 4 FSC input. It measures the width of pulses in the composite sync input to separate vertical, horizontal, and serration pulses and to insert the subcarrier burst only after a valid horizontal sync pulse.
Asserting the ENCD pin to a logical low routes the AD721's RGB inputs through three gain-of-two bypass buffers for driving $75 \Omega$ reverse-terminated lines, bypassing the encoder section of the AD721. The triple bypass amplifier is utilized to overcome the loading effects of a "TV-out" connection on the RGB monitor output. When a video encoder is connected to outputs of a current-out video RAMDAC or VGA controller, the R, G, and $B$ signals to the monitor are loaded-down. This requires the use of a gain block to properly drive the monitor.


Figure 8. AD720/AD721 Functional Block Diagram

## APPLYING THE AD720/AD721

Figure 9 shows the application of the AD720 and Figure 10 shows the application of the AD721. Note that the AD720 and AD721 differ from other analog encoders because they are dc coupled. This means that, for example, the expected RGB inputs are 0 mV to 714 mV in NTSC and 0 mV to 700 mV in PAL. The luminance, chrominance, and composite outputs are also dc coupled. These outputs can drive a $75 \Omega$ reverseterminated load. Unused outputs should be terminated with $150 \Omega$ resistors.

The RGB data must be supplied to the AD720/AD721 at NTSC or PAL rates, interlaced format. Various VGA chip set vendors support this mode of operation. Most computers supply RGB outputs in noninterlaced format at higher data rates than NTSC and PAL, which means that "outboard" encoders must supply some form of timing conversion before the RGB data reaches the AD720/AD721.


Figure 9. AD720 Application


Figure 10. AD721 Application

## AD720/AD721

Note also that the AD720/AD721 does not have internal dc restoration and does not accept sync on green. The composite sync input is a separate, CMOS logical-level input and must be synchronized with the 4FSC input, which serves as the master clock for the AD720/AD721.
The AD720/AD721 does not implement two elements of the PAL and NTSC standards. In NTSC operation, it does not support the 7.5 IRE unit setup (1 IRE unit $=7.14 \mathrm{mV}$ )-this must be added via software using the RGB inputs. Many RAMDACs, such as the Analog Devices ADV471 and ADV478, offer a logic-selectable setup mode. In PAL operation, the AD720/ AD721 does not implement a 25 Hz subcarrier offset.

## Decoupling and Grounding

Referring to the pin descriptions, the AD720/AD721 uses multiple analog grounds, digital grounds, digital positive supply inputs, analog positive supply inputs, and analog negative supply inputs in order to maximize isolation between analog and digital signal paths.
The most sensitive input of the AD720/AD721 is the 4FSC pin: any noise on this pin directly affects the subcarrier and causes degradation of the picture. Digital and analog grounds should be kept separate and brought together at a single point.
All power supply pins should be decoupled using $0.1 \mu \mathrm{~F}$ ceramic capacitors located as close to the AD720/AD721 as possible. In addition, ferrite beads may be slipped over the power supply leads to reduce high frequency noise.
If a high speed RAM-DAC is used (e.g., capable of 80 MHz operation with subnanosecond rise times), care must be taken to properly terminate the input printed-circuit-board traces to the AD720/AD721. Otherwise, ringing on these traces may occur and cause degradation of the picture.

## APPLICATIONS HINTS

In applying the $\mathrm{AD} 720 / \mathrm{AD} 721$, problems may arise due to incorrect input signals. A few common situations follow.
Fade to Black or White-Invalid Horizontal Sync Pulses Some systems produce sync pulses that are longer or shorter than the NTSC and PAL standards specify. The digital sync separator in the AD720/AD721 ignores horizontal sync pulses that are too long or too short. Figure 11 shows the timing windows for valid NTSC and PAL horizontal sync pulses.

When the horizontal sync pulses are too long or too short, a dc offset voltage (due to charge storage) increases on the output of the sampled data delay line's auto-zero amplifier. Normally, this offset voltage is removed at the beginning of every line, as signified by the horizontal sync pulse. Without the horizontal sync pulse, the dc offset on the auto-zero amplifier increases over time (usually about three to five minutes) until it overrides the luminance information. The end result is a slow fade to black or white.

## Color Flickering-Asynchronous Operation

The AD720/AD721 requires that its 4FSC and composite sync signals be synchronized. In most systems, when the two signals are synchronized, the composite sync signal is generated using a 4FSC signal as the reference. After every four frames, the AD720/AD721 resets the phase quadrature generator. When the CSYNC and 4FSC are synchronized, this reset is transparent to the system because the reference phase does not change. When the CSYNC and 4FSC are not synchronized, the difference between the reference phase and its new value upon reset causes an instantaneous color shift, which appears as a flickering in the color.

## Adding NTSC Setup

The easiest way to add the 7.5 IRE unit ${ }^{1}$ setup is to use a ADV471/478 or ADV477/475 or ADV473 type RAM-DAC, which have a logic-selectable setup (called "pedestal" on some data sheets and "setup" on others).

## Color Fidelity

A source impedance other than $37.5 \Omega(75 \Omega|\mid 75 \Omega$-a reverse-terminated $75 \Omega$ input) can cause errors in the YUV encoding matrix, which is basically resistive and depends on the correct source impedance for accuracy. Figures 9 and 10 show the correct interface between a RAM-DAC and the AD720 and AD721 respectively, using $75 \Omega$ reverse-terminated connections.

NOTE

${ }^{1}$ IRE unit $=7.14 \mathrm{mV}$.


Figure 11. NTSC and PAL Timing for Valid Horizontal Sync Pulses

## FEATURES

Doubly-Balanced Mixer
Low Distortion
+24 dBm Third Order Intercept (IP3)
+10 dBm 1 dB Compression Point
Low LO Drive Required: - $\mathbf{1 0} \mathbf{~ d B m}$
Bandwidth
500 MHz RF and LO Input Bandwidths
250 MHz Differential Current IF Output
DC to $\boldsymbol{>} \mathbf{2 0 0} \mathbf{~ M H z}$ Single-Ended Voltage IF Output
Single or Dual Supply Operation
DC Coupled Using Dual Supplies
All Ports May Be DC Coupled
No Lower Frequency Limit-Operation to DC
User-Programmable Power Consumption

## APPLICATIONS

High Performance RF/IF Mixer
Direct to Baseband Conversion
Image-Reject Mixers
I/Q Modulators and Demodulators

## PRODUCT DESCRIPTION

The AD831 is a low distortion, wide dynamic range, monolithic mixer for use in such applications as RF to IF down conversion in HF and VHF receivers, the second mixer in DMR base stations, direct-to-baseband conversion, quadrature modulation and demodulation, and doppler-shift detection in ultrasound imaging applications. The mixer includes an LO driver and a low-noise output amplifier and provides both userprogrammable power consumption and 3rd-order intercept point.
The AD831 provides a +24 dBm third-order intercept point for -10 dBm LO power, thus improving system performance and reducing system cost compared to passive mixers, by eliminating the need for a high power LO driver and its attendant shielding and isolation problems.
The RF, IF, and LO ports may be dc or ac coupled when the mixer is operating from $\pm 5 \mathrm{~V}$ supplies or ac coupled when operating from a single supply of 9 V minimum. The mixer operates with RF and LO inputs as high as 500 MHz .
The mixer's IF output is available as either a differential current output or a single-ended voltage output. The differential output is from a pair of open collectors and may be ac coupled via a transformer or capacitor to provide a 250 MHz output bandwidth. In down-conversion applications, a single capacitor connected across these outputs implements a low-pass filter to reduce harmonics directly at the mixer core, simplifying output

## FUNCTIONAL BLOCK DIAGRAM


filtering. When building a quadrature-amplitude modulator or image reject mixer, the differential current outputs of two AD831s may be summed by connecting them together.
An integral low noise amplifier provides a single-ended voltage output and can drive such low impedance loads as filters, $50 \Omega 2$ amplifier inputs, and A/D converters. Its small signal bandwidth exceeds 200 MHz . A single resistor connected between pins OUT and FB sets its gain. The amplifier's low dc offset allows its use in such direct-coupled applications as direct-to-baseband conversion and quadrature-amplitude demodulation.
The mixer's SSB noise figure is 12 dB using its output amplifier and optimum source impedance. Unlike passive mixers, the AD831 has no insertion loss and does not require an external diplexer or passive termination.
A programmable-bias feature allows the user to reduce power consumption, with a reduction in the 1 dB compression point and third-order intercept. This permits a tradeoff between dynamic range and power consumption. For example, the AD831 may be used as a second mixer in cellular and two-way radio base stations at reduced power while still providing a substantial performance improvement over passive solutions.

## PRODUCT HIGHLIGHTS

1. -10 dBm LO Drive for $\mathrm{a}+24 \mathrm{dBm}$ Output Referred Third Order Intercept Point
2. Single-Ended Voltage Output
3. High Port-to-Port Isolation
4. No Insertion Loss
5. Single or Dual Supply Operation

| Parameter | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| RF INPUT <br> Bandwidth <br> Maximum Input Level Common-Mode Range Bias Current Resistance Capacitance | -10 dBm Signal Level, IP3 $\geq+20 \mathrm{dBm}$ 10.7 MHz IF and High Side Injection See Figure 1 <br> DC Coupled <br> Differential or Common Mode |  | $\begin{aligned} & 400 \\ & 10 \\ & 160 \\ & 1.3 \\ & 2 \end{aligned}$ | $\pm 1$ 500 | MHz <br> dBm <br> V <br> $\mu \mathrm{A}$ <br> $\mathrm{k} \Omega$ <br> pF |
| IF OUTPUT <br> Bandwidth <br> Conversion Gain Output Offset Voltage Slew Rate Output Voltage Swing Short Circuit Current | Single-Ended Voltage Output, -3 dB <br> Level $=0 \mathrm{dBm}, \mathrm{R}_{\mathrm{L}}=100 \Omega$ <br> Terminals OUT and VFB Connected DC Measurement; LO Input Switched $\pm 1$ $\mathrm{R}_{\mathrm{L}}=100 \Omega \text {, Unity Gain }$ | -40 | $\begin{aligned} & 200 \\ & 0 \\ & 15 \\ & 300 \\ & \pm 1.4 \\ & 75 \end{aligned}$ | +40 | MHz <br> dB <br> mV <br> $\mathrm{V} / \mu \mathrm{s}$ <br> V <br> mA |
| LO INPUT <br> Bandwidth <br> Maximum Input Level Common Mode Range Minimum Switching Level Bias Current Resistance Capacitance | -10 dBm Input Signal Level <br> 10.7 MHz IF and High Side Injection <br> Differential Input Signal <br> DC Coupled <br> Differential or Common Mode | $\begin{aligned} & -1 \\ & -1 \end{aligned}$ | $\begin{aligned} & 400 \\ & \\ & 200 \\ & 17 \\ & 500 \\ & 2 \end{aligned}$ | $\begin{aligned} & +1 \\ & +1 \\ & 50 \end{aligned}$ | MHz <br> V <br> V <br> mV p-p <br> $\mu \mathrm{A}$ <br> $\Omega$ <br> pF |
| ISOLATION BETWEEN PORTS <br> LO to RF <br> LO to IF <br> RF to IF | $\begin{aligned} & \mathrm{LO}=100 \mathrm{MHz}, \mathrm{R}_{\mathrm{s}}=50 \Omega, 10.7 \mathrm{MHz} \mathrm{IF} \\ & \mathrm{LO}=100 \mathrm{MHz}, \mathrm{R}_{\mathrm{S}}=50 \Omega, 10.7 \mathrm{MHz} \mathrm{IF} \\ & \mathrm{RF}=100 \mathrm{MHz}, \mathrm{R}_{\mathrm{s}}=50 \Omega, 10.7 \mathrm{MHz} \mathrm{IF} \end{aligned}$ |  | $\begin{aligned} & 70 \\ & 30 \\ & 45 \end{aligned}$ |  | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \end{aligned}$ |
| DISTORTION AND NOISE <br> 3rd Order Intercept <br> 2rd Order Intercept <br> 1 dB Compression Point <br> Noise Figure, SSB | $\mathrm{LO}=-10 \mathrm{dBm}, \mathrm{f}=100 \mathrm{MHz}$ <br> Output Referred, $\pm 100 \mathrm{mV}$ LO Input Output Referred, $\pm 100 \mathrm{mV}$ LO Input $\mathrm{R}_{\mathrm{L}}=100 \Omega, \mathrm{R}_{\mathrm{BIAS}}=\infty$ <br> For Optimum Source Impedance |  | $\begin{aligned} & 24 \\ & 62 \\ & 10 \\ & 12 \end{aligned}$ |  | dBm <br> dBm <br> dBm <br> dB |
| POWER SUPPLIES <br> Recommended Supply Range <br> Quiescent Current ${ }^{1}$ | Dual Supply <br> Single Supply <br> For Best 3rd Order Intercept Point Performance BIAS Pin Open Circuited | $\begin{aligned} & \pm 4.5 \\ & 9 \end{aligned}$ | 100 | $\begin{aligned} & \pm 5.5 \\ & 11 \\ & 125 \end{aligned}$ | $\begin{aligned} & \text { V } \\ & \text { V } \end{aligned}$ $\mathrm{mA}$ |

## NOTES

${ }^{1}$ Quiescent current is programmable.
Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

Supply Voltage $\pm \mathrm{V}_{\text {S }}$. . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 5.5 \mathrm{~V}$ Input Voltages

RFHI, RFLO . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 3$ V
LOHI, LOLO . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 1$ V
Internal Power Dissipation ${ }^{2}$. . . . . . . . . . . . . . . . . . . . . 1200 mW
Operating Temperature Range
AD831A . . . . . . . . . . . . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature Range (Soldering 60 sec ) . . . . . . . $+300^{\circ} \mathrm{C}$ NOTES
'Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
'Thermal Characteristics:
20-Pin PLCC Package: $\theta_{\mathrm{JA}}=110^{\circ} \mathrm{C} / \mathrm{W}$ att; $\theta_{\mathrm{K}}=20^{\circ} \mathrm{C} / \mathrm{Watt}$.
Note that the $\theta_{\mathrm{JA}}=110^{\circ} \mathrm{C} / \mathrm{W}$ value is for the package measured while suspended in still air; mounted on a PC board, the typical value is $\theta_{\mathrm{A}}=90^{\circ} \mathrm{C} / \mathrm{W}$ due to the conduction provided by the AD831's package being in contact with the board, which serves as a heat sink.

## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD831AP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 20-Lead PLCC | P-20A |

[^272]
## PIN CONFIGURATION

20-Lead PLCC


PIN DESCRIPTION

| Pin | Mnemonic | Description |
| :--- | :--- | :--- |
| 1 | VP | Positive Supply Input |
| 2 | IFN | Mixer Current Output |
| 3 | AN | Amplifier Negative Input |
| 4 | GND | Ground |
| 5 | VN | Negative Supply Input |
| 6 | RFP | RF Input |
| 7 | RFN | RF Input |
| 8 | VN | Negative Supply Input |
| 9 | VP | Positive Supply Input |
| 10 | LON | Local Oscillator Input |
| 11 | LOP | Local Oscillator Input |
| 12 | VP | Positive Supply Input |
| 13 | GND | Ground |
| 14 | BIAS | Bias Input |
| 15 | VN | Negative Supply Input |
| 16 | OUT | Amplifier Output |
| 17 | VFB | Amplifier Feedback Input |
| 18 | COM | Amplifier Output Common |
| 19 | AP | Amplifier Positive Input |
| 20 | IFP | Mixer Current Output |

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD831 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

## AD831-Typical Characteristics



Figure 1. Third-Order Intercept vs. Frequency


Figure 2. IF-to-RF Isolation vs. Frequency


Figure 3. LO-to-IF Isolation vs. Frequency


Figure 4. Second-Order Intercept vs. Frequency


Figure 5. LO-to-RF Isolation vs. Frequency


Figure 6. RF-to-IF Isolation vs. Frequency


Figure 7. $1 d B$ Compression Point vs. Frequency, Gain $=1$


Figure 8. $1 d B$ Compression Point vs. Frequency, Gain $=2$


Figure 9. Gain Error vs. Frequency for Figure 7, Gain $=1$

Figure 10. $1 d B$ Compression Point vs. Frequency, Gain $=4$


Figure 11. Third-Order Intercept vs. Frequency, LO Held Constant at 241 MHz

## THEORY OF OPERATION

The AD831 consists of a mixer core, a limiting amplifier, a low noise output amplifier, and a bias circuit (Figure 12).
The mixer's RF input is converted into differential currents by a highly linear, Class A voltage-to-current converter, formed by transistors Q1, Q2 and resistors R1, R2. The resulting currents drive the differential pairs Q3, Q4 and Q5, Q6. The LO input is through a high gain, low noise limiting amplifier that converts the -10 dBm LO input into a square wave. This square wave drives the differential pairs Q3, Q4 and Q5, Q6 and produces a high level output at IFP and IFN-consisting of the sum and difference frequencies of the RF and LO inputs-and a series of lower level outputs caused by odd harmonics of the LO frequency mixing with the RF input.
An on-chip network supplies the bias current to the RF and LO inputs when these are ac coupled; this network is disabled when the AD831 is dc coupled.

When the integral output amplifier is used, pins IFN and IFP are connected directly to pins AFN and AFP; the on-chip load resistors convert the output current into a voltage that drives the output amplifier. The ratio of these load resistors to resistors R1, R2 provides nominal unity gain ( 0 dB ) from RF to IF. The expression for the gain, in decibels, is

$$
G_{d B}=20 \log _{10}\left(\frac{4}{\pi}\right)\left(\frac{1}{2}\right)\left(\frac{\pi}{2}\right)
$$

where
$\frac{4}{\pi}$ is the amplitude of the fundamental component of a square wave $\frac{1}{2}$ is the conversion loss
$\frac{\pi}{2}$ is the small signal dc gain of the AD831 when the LO input is driven fully positive or negative.


Figure 12. AD831 Simplified Schematic Diagram


Figure 13. Connections for Transformer Coupling to the IF Output
The mixer has two open-collector outputs (differential currents) at pins IFN and IFP. These currents may be used to provide nominal unity RF-to-IF gain by connecting a centertapped transformer (1:1 turns ratio) to pins IFN and IFP as shown in Figure 13.

## Programming the Bias Current

Because the AD831's RF port is a Class-A circuit, the maximum RF input is proportional to the bias current. This bias current may be reduced by connecting a resistor from the BIAS pin to the positive supply (Figure 14). For normal operation, the BIAS pin is left unconnected. For lowest power consumption, the BIAS pin is connected directly to the positive supply The range of adjustment is 100 mA for normal operation to 45 mA total current at minimum power consumption.


Figure 14. Programming the Quiescent Current

## Low-Pass Filtering

A simple low-pass filter may be added between the mixer and the output amplifier by shunting the internal resistive loads (an
equivalent resistance of about $14 \Omega$ with a tolerance of $20 \%$ ) with external capacitors; these attenuate the sum component in a down-conversion application (Figure 15). The corner frequency of this one-pole low-pass filter $\left(f=\left(2 \pi \mathrm{RC}_{\mathrm{F}}\right)^{-1}\right)$ should be placed about an octave above the difference frequency IF. Thus, for a 70 MHz IF, a -3 dB frequency of 140 MHz might be chosen, using $\mathrm{C}_{\mathrm{F}}=(2 \times \pi \times 14 \Omega \times 140 \mathrm{MHz})^{-1} \approx 82 \mathrm{pF}$, the nearest standard value.


Figure 15. Low-Pass Filtering Using External Capacitors

## Using the Output Amplifier

The AD831's output amplifier converts the mixer core's differential current output into a single-ended voltage and provides an output as high as $\pm 1 \mathrm{~V}$ peak into a $50 \Omega$ load ( +10 dBm ). For unity gain operation (Figure 16), the inputs AN and AP connect to the open-collector outputs of the mixer's core and OUT connects to VFB.
For gains other than unity, the amplifier's output at OUT is connected via an attenuator network to VFB; this determines the overall gain. Using resistors R1 and R2 (Figure 17), the gain setting expression is

$$
G_{d B}=20 \log _{10}\left(\frac{R 1+R 2}{R 2}\right)
$$

Equation 2


Figure 16. Output Amplifier Connected for Unity Gain Operation


Figure 17. Output Amplifier Feedback Connections for Increasing Gain

## Driving Filters

The output amplifier can be used for driving reverse-terminated loads. When driving an IF bandpass filter (BPF), for example, proper attention must be paid to providing the optimal source and load terminations so as to achieve the specified filter response. The AD831's wideband highly linear output amplifier affords an opportunity to increase the RF-to-IF gain to compensate for a filter's insertion and termination losses.
Figure 18 indicates how the output amplifier's low impedance (voltage source) output can drive a doubly-terminated bandpass filter. The typical 10 dB of loss $(4 \mathrm{~dB}$ of insertion loss and 6 dB due to the reverse-termination) be made up by the inclusion of a feedback network that increases the gain of the amplifier by $10 \mathrm{~dB}(\times 3.162)$. When constructing a feedback circuit, the signal path between OUT and VFB should be as short as possible.
Higher gains can be achieved, using different resistor ratios, but with concomitant reduction in the bandwidth of this amplifier (Figure 19). Note also that the Johnson noise of these gainsetting resistors, as well as that of the BPF terminating resistors, is ultimately reflected back to the mixer's input; thus they should be as small as possible, consistent with the permissible loading on the amplifier's output.


Figure 18. Connections for Driving a Doubly-Terminated Bandpass Filter


Figure 19. Output Amplifier $1 d B$ Compression Point for Gains of 1, 2, and 4 (Gains of $0 d B, 6 d B$, and $12 d B$, respectively)

## APPLICATIONS

Careful component selection; circuit layout, power supply decoupling, and shielding are needed to minimize the AD831's susceptibility to interference from radio and TV stations, etc. In bench evaluation, we recommend placing all of the components in a shielded box and using feedthrough decoupling networks for the supply voltage.

Circuit layout and construction are also critical, since stray capacitances and lead inductances can form resonant circuits and are a potential source of circuit peaking, oscillation, or both.

## Dual-Supply Operation

Figure 20 shows the connections for dual supply operation. Supplies may be as low as $\pm 4.5 \mathrm{~V}$ but should be no higher than $\pm 5.5 \mathrm{~V}$ due to power dissipation.

The RF input to the AD831 is shown connected single-ended to pin RFP with $51.1 \Omega$ input termination resistor with an assumed source impedance of $50 \Omega$. The 82 pF capacitors $\left(\mathrm{C}_{\mathrm{F}}\right)$ connected from IFN and IFP to VP provide a low-pass filter with a cutoff frequency of approximately 140 MHz in down-conversion applications (see the Theory of Operation section of this data sheet for more details). The LO input is connected single-ended because the limiting amplifier provides a symmetric drive to the mixer. To minimize intermodulation distortion, connect pins OUT and VFB by the shortest possible path. The connections shown are for unity-gain operation.

At LO frequencies less than 100 MHz , the AD831's LO power may be as low as -20 dBm for satisfactory operation. Above 100 MHz , the specified LO power of -10 dBm must be used.


Figure 20. Connections for $\pm 5$ V Dual-Supply Operation

## Single Supply Operation

Figure 21 is similar to the dual supply circuit in Figure 19. Supplies may be as low as 9 V but should not be higher than 11 V due to power dissipation. As in Figure 19, both the RF and LO ports are driven single-ended and terminated.

In single supply operation, the COM terminal is the "ground" reference for the output amplifier and must be biased to $1 / 2$ the supply voltage, which is done by resistors R1 and R2. The OUT pin must be ac-coupled to the load.


Figure 21. Connections for +9 V Single-Supply Operation

## Connections Quadrature Demodulation

Two AD831 mixers may have their RF inputs connected in parallel and have their LO inputs driven in phase quadrature (Figure 22) to provide demodulated in-phase (I) and quadra-
ture (Q) outputs. The mixers' inputs may be connected in parallel and a single termination resistor used if the mixers are located in close proximity on the PC board.


Figure 22. Connections for Quadrature Demodulation


Figure 23. Third-Order Intercept Characterization Setup


Figure 24. IF to RF Isolation Characterization Setup

CMOS

## FEATURES

Single +5 V Supply
32-Bit Phase Accumulator
On-Chip COSINE and SINE Look-Up Tables On-Chip 10-Bit DAC
Frequency, Phase and Amplitude Modulation Parallel and Serial Loading
Software and Hardware Power Down Options
20 MHz and 50 MHz Speed Grades
44-Pin PLCC

## APPLICATIONS

Frequency Synthesizers
Frequency, Phase or Amplitude Modulators
DDS Tuning
Digital Demodulation

## GENERAL DESCRIPTION

The AD7008 direct digital synthesis chip is a numerically controlled oscillator employing a 32-bit phase accumulator, sine and cosine look-up tables and a 10 -bit D/A converter integrated on a
single CMOS chip. Modulation capabilities are provided for phase modulation, frequency modulation, and both in-phase and quadrature amplitude modulation suitable for SSB generation.
Clock rates up to 20 MHz and 50 MHz are supported. Frequency accuracy can be controlled to one part in 4 billion. Modulation may be effected by loading registers either through the parallel microprocessor interface or the serial interface. A frequency-select pin permits selection between two frequencies on a per cycle basis.
The serial and parallel interfaces may be operated independently and asynchronously from the DDS clock; the transfer control signals are internally synchronized to prevent metastability problems. The synchronizer can be bypassed to reduce the transfer latency in the event that the microprocessor clock is synchronous with the DDS clock.

A power-down pin allows external control of a power-down mode (also accessible through the microprocessor interface). The AD7008 is available in 44-pin PLCC.

## FUNCTIONAL BLOCK DIAGRAM




| Parameter | AD7008AP20 | AD7008JP50 | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: |
| SIGNAL DAC SPECIFICATIONS <br> Resolution <br> No. of Channels <br> Update Rate ( $\mathrm{f}_{\text {MAX }}$ ) <br> IOUT Full Scale <br> Output Compliance <br> DC Accuracy <br> Integral Nonlinearity <br> Differential Nonlinearity | $\begin{array}{\|l} 10 \\ 1 \\ 20 \\ 20 \\ 1 \\ \pm 1 \\ \pm 1 \end{array}$ | $\begin{aligned} & 10 \\ & 1 \\ & 50 \\ & 20 \\ & 1 \\ & \pm 1 \\ & \pm 1 \end{aligned}$ | Bits <br> Msps max <br> mA max <br> Volts max <br> LSB typ <br> LSB typ |  |
| DDS SPECIFICATIONS ${ }^{2}$ <br> Dynamic Specifications <br> Signal-to-Noise Ratio <br> Total Harmonic Distortion <br> Spurious Free Dynamic Range (SFDR) ${ }^{3}$ <br> Narrow Band ( $\pm 50 \mathrm{kHz}$ ) <br> Wide Band ( $\pm 2 \mathrm{MHz}$ ) <br> Power-Down Option | $\left\lvert\, \begin{aligned} & 50 \\ & -55 \\ & -70 \\ & -55 \\ & -5 e s \end{aligned}\right.$ | $\begin{aligned} & 50 \\ & -53 \\ & -70 \\ & -55 \\ & -5 e s \\ & \hline \end{aligned}$ | dB min dB min dB min dB min | $\begin{aligned} & \mathrm{f}_{\mathrm{CLK}}=\mathrm{f}_{\mathrm{MAX}}, \mathrm{f}_{\mathrm{OUT}}=2 \mathrm{MHz} \\ & \mathrm{f}_{\mathrm{CLK}}=\mathrm{f}_{\mathrm{MAX}}, \mathrm{f}_{\mathrm{OUT}}=2 \mathrm{MHz} \\ & \mathrm{f}_{\mathrm{CLK}}=6.25 \mathrm{MHz}, \mathrm{f}_{\mathrm{OUT}}=2.11 \mathrm{MHz} \end{aligned}$ |
| $\begin{aligned} & \text { VOLTAGE REFERENCE } \\ & \text { Internal Reference @ }+25^{\circ} \mathrm{C} \\ & \mathrm{~T}_{\text {MIN }} \text { to } \mathrm{T}_{\text {MAX }} \\ & \text { Reference TC } \end{aligned}$ | $\begin{array}{\|l\|} 1.27 \\ 1.2 / 1.35 \\ 300 \end{array}$ | $\begin{aligned} & 1.27 \\ & 1.2 / 1.35 \\ & 300 \end{aligned}$ | Volts typ <br> Volts $\min /$ max <br> ppm $/{ }^{\circ} \mathrm{C}$ typ |  |
| LOGIC INPUTS <br> $\mathrm{V}_{\text {INH }}$, Input High Voltage $\mathrm{V}_{\text {INL }}$, Input Low Voltage $\mathrm{I}_{\text {INH }}$, Input Current $\mathrm{C}_{\mathrm{IN}}$, Input Capacitance | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}{ }^{-0.9} 9 \\ & 0.9 \\ & 10 \\ & 10 \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}-0.9 \\ & 0.9 \\ & 10 \\ & 10 \end{aligned}$ | V min V max $\mu \mathrm{A}$ max pF max |  |
| POWER SUPPLIES <br> $V_{D D}$ <br> $\mathrm{I}_{\mathrm{AA}}$ <br> $I_{D D}$ <br> $\mathrm{I}_{\mathrm{AA}}+\mathrm{I}_{\mathrm{DD}}{ }^{4}$ | $\begin{aligned} & 4.75 / 5.25 \\ & 26 \\ & 22+1.5 / \mathrm{MHz} \\ & 80 \\ & 110 \\ & 10 \end{aligned}$ | $\begin{aligned} & 4.75 / 5.25 \\ & 26 \\ & 22+1.5 / \mathrm{MHz} \\ & 125 \\ & 160 \\ & 20 \end{aligned}$ | $\begin{aligned} & V \min / V \max \\ & m A \text { typ } \\ & m A \text { typ } \\ & m A \text { typ } \\ & m A \max \\ & m A \max \end{aligned}$ | $\begin{aligned} & \mathrm{R}_{\text {SET }}=390 \Omega \\ & \text { SLEEP }=0 \mathrm{~V} ; \mathrm{CR} 2=0 \text { (AM Disabled) } \\ & \mathrm{f}_{\mathrm{CLK}}=\mathrm{f}_{\mathrm{MAX}} \\ & \mathrm{SLEEP}=\mathrm{V}_{\mathrm{DD}} \end{aligned}$ |

## NOTES

${ }^{1}$ Operating temperature ranges as follows: A Version: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; J Version: $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$.
${ }^{2}$ All dynamic specifications are measured using IOUT. 100\% Production tested.
${ }^{3} \mathrm{f}_{\mathrm{CLK}}=6.25 \mathrm{MHz}$, Frequency Word $=5671 \mathrm{C} 71 \mathrm{C}$ HEX, $\mathrm{f}_{\mathrm{OUT}}=2.11 \mathrm{MHz}$.
${ }^{4}$ With AM enabled $(\mathrm{CR} 2=1), \mathrm{T}_{\text {MAX }}$ should be limited as follows: AD7008AP20, $\mathrm{T}_{\mathrm{MAX}}=+70^{\circ} \mathrm{C} ; \mathrm{AD} 7008 \mathrm{JP} 50, \mathrm{~T}_{\mathrm{MAx}}=+55^{\circ} \mathrm{C}$.
Specifications subject to change without notice.


| Parameter | AD7008AP20 | AD7008JP50 | Units | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{1}$ | 50 | 20 | ns min | CLOCK Period |
| $\mathrm{t}_{2}$ | 20 | 8 | ns min | CLOCK High Duration |
| $\mathrm{t}_{3}$ | 20 | 8 | ns min | CLOCK Low Duration |
| $\mathrm{t}_{4}$ | 5 | 5 | ns min | CLOCK to Control Setup Time |
| ${ }^{\text {t }}$ | 3 | 3 | ns min | CLOCK to Control Hold Time |
| $\mathrm{t}_{6}$ | $4 \mathrm{t}_{1}$ | $4 \mathrm{t}_{1}$ | ns min | LOAD Period |
| $\mathrm{t}_{7}$ | $2 \mathrm{t}_{1}$ | $2 \mathrm{t}_{1}$ | ns min | LOAD High Duration |
| $\mathrm{t}_{8}$ | 5 | 5 | ns min | LOAD High to TC0-TC3 Setup Time |
| $\mathrm{t}_{9}$ | 5 | 5 | ns min | LOAD High to TC0-TC3 Hold Time |
| $\mathrm{t}_{10}$ | 10 | 10 | ns min | $\overline{\text { WR }}$ Rising to $\overline{\mathrm{CS}}$ Low Setup Time |
| $\mathrm{t}_{11}$ | 10 | 10 | ns min | $\overline{\text { WR }}$ Rising to $\overline{\mathrm{CS}}$ Low Hold Time |
| $\mathrm{t}_{12}$ | 20 | 20 | ns min | Minimum WR Low Duration |
| $\mathrm{t}_{13}$ | 10 | 10 | ns min | Minimum WR High Duration |
| $\mathrm{t}_{14}$ | 3 | 3 | ns min | $\overline{\text { WR }}$ to D0-D15 Setup Time |
| $\mathrm{t}_{15}$ | 3 | 3 | ns min | $\overline{\text { WR }}$ to D0-D15 Hold Time |
| $\mathrm{t}_{16}$ | 20 | 20 | ns min | SCLK Period |
| $\mathrm{t}_{17}$ | 8 | 8 | ns min | SCLK High Duration |
| $\mathrm{t}_{18}$ | 8 | 8 | ns min | SCLK Low Duration |
| $\mathrm{t}_{19}$ | 10 | 10 | $n \mathrm{~ns} \min$ | SCLK Rising to SDATA Setup Time |
| $\mathrm{t}_{20}$ | 10 | 10 | ns min | SCLK Rising to SDATA Hold Time |



Figure 1. Clock Synchronization Timing


Figure 3. Parallel Port Timing


Figure 4. Serial Port Timing

## ABSOLUTE MAXIMUM RATINGS*

( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)
$\mathrm{V}_{\mathrm{AA}}, \mathrm{V}_{\mathrm{DD}}$ to GND . . . . . . . . . . . . . . . . . -0.3 V to +7 V
AGND to DGND . . . . . . . . . . . . . . . . . -0.3 V to +0.3 V
Digital I/O Voltage to DGND . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Analog I/O Voltage to AGND . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Operating Temperature Range
Industrial (A Version) . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Commercial (J Version) . . . . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 secs) . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Junction Temperature . . . . . . . . . . . . . . . . . . . . . . $+115^{\circ} \mathrm{C}$
PLCC $\theta_{\mathrm{JA}}$ Thermal Impedance . . . . . . . . . . . . . . . $+55^{\circ} \mathrm{C} / \mathrm{W}$
*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## ORDERING GUIDE

| Model | Temperature <br> Range | Package <br> Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD7008AP20 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 44-Pin PLCC | P-44A |
| AD7008JP50 | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 44-Pin PLCC | P-44A |



Figure 5. 16-Bit Parallel Port Loading Sequence


Figure 6. 8-Bit Parallel Port Loading Sequence
${ }^{\star}$ For outline information see Package Information section.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD7008 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

PIN CONFIGURATION
PLCC


## Mnemonic Function

## POWER SUPPLY

| $\mathrm{V}_{\mathrm{AA}}$ | Positive power supply for the analog section. A $0.1 \mu \mathrm{~F}$ decoupling capacitor should be connected between $\mathrm{V}_{\mathrm{AA}}$ and |
| :--- | :--- |
|  | AGND. This is $+5 \mathrm{~V} \pm 5 \%$. |
| AGND | Analog Ground. |
| $\mathrm{V}_{\mathrm{DD}}$ | Positive power supply for the digital section. A $0.1 \mu \mathrm{~F}$ decoupling capacitor should be connected between $\mathrm{V}_{\mathrm{DD}}$ and |
|  | DGND. This is $+5 \mathrm{~V} \pm 5 \%$. Both $\mathrm{V}_{\mathrm{AA}}$ and $\mathrm{V}_{\mathrm{DD}}$ should be externally tied together. |
| DGND | Digital Ground; both grounds should be externally tied together. |

## ANALOG SIGNAL AND REFERENCE

IOUT, $\overline{\text { IOUT }}$ Current Output. This is a high impedance current source. A load resistor should be connected between IOUT and AGND. IOUT should be either tied directly to AGND or through an external load resistor to AGND.

| FS | Full-Scale Adjust Control. A resistor ( $\mathrm{R}_{\mathrm{SET}}$ ) is connected between this pin and AGND. This determines the magnitude of the full-scale DAC current. The relationship between $\mathrm{R}_{\mathrm{SET}}$ and the full-scale current is as follows: $\operatorname{IOUT}_{F U L L-S C A L E}(m A)=6233 \times V_{R E F}(V) / R_{S E T}(\Omega)$ |
| :---: | :---: |
| $\mathrm{V}_{\text {RE }}$ | Voltage Reference Input. A $0.1 \mu \mathrm{~F}$ decoupling ceramic capacitor should be connected $\mathrm{V}_{\text {REF }}$ and $\mathrm{V}_{\mathrm{AA}}$. There is an internal 1.27 voltage reference which can over driven by an external reference if required. |
| COMP | Compensation pin. This is a compensation pin for the internal reference amplifier. A $0.1 \mu \mathrm{~F}$ decoupling ceramic capacitor should be connected between COMP and $\mathrm{V}_{\mathrm{AA}}$. |

## DIGITAL INTERFACE AND CONTROL

| CLOCK | Digital Clock Input. DDS output frequencies are expressed as a binary fraction of the frequency of this clock. Hence, the output frequency accuracy and phase noise is determined by this clock. |
| :---: | :---: |
| FSELECT | Frequency Select Input. FSELECT controls which frequency register, FREQ0 or FREQ1, is used in the phase accumulator. Frequency selection can be done on a cycle-per-cycle basis. |
| LOAD | Register load, active high digital Input. This pin, in conjunction with TC3-TC0, control loading of internal registers from either the parallel or serial assembly registers. |
| TC3-TC0 | Transfer Control address bus, digital inputs. This address determines the source and destination registers that are used during a transfer. The source register can either be the parallel assembly register or the serial assembly register. The destination register can be any of the following: COMMAND REG, FREQ0 REG, FREQ1 REG, PHASE REG or IQMOD REG. TC3-TC0 should be valid prior to LOAD rising and should not change until LOAD falls. |
| $\overline{\text { CS }}$ | Chip Select, active low digital input. This input in conjunction with $\overline{\mathrm{WR}}$ is used when writing to the parallel assembly register. |
| $\overline{\mathrm{WR}}$ | Write, active low digital input. This input in conjunction with $\overline{\mathrm{CS}}$ is used when writing to the parallel assembly register. |
| D7-D0 | Data bus, digital inputs. This represent the low byte of the 16 -bit data input port used to write to the 32 -bit parallel assembly register. The databus can configured for either a 8 -bit or 16 -bit MPU/DSP ports. |
| D15-D8 | Data Bus, Digital Inputs. This represent the high byte of the 16 -bit data input port used to write to the 32 -bit parallel assembly register. The databus can configured for either a 8 -bit or 16 -bit MPU/DSP ports. When the databus is configured for 8 -bit operation, D8-D15 should be tied to DGND. |
| SCLK | Serial Clock, digital input. SCLK is used, in conjunction with SDATA, to clock data into the 32-bit serial assembly register. |
| SDATA | Serial Data, digital input. Serial data is clocked on the rising edge of SCLK, Most Significant Bit (MSB) first. |
| SLEEP | Low power sleep control, active high digital input. SLEEP puts the AD7008 into a low power sleep mode. Internal clocks are disable while also turning off the DAC current sources. A SLEEP bit is also provided in the COMMAND REG to put the AD7008 into a low power sleep mode. |
| RESET | Register Reset, active high digital input. RESET clears the COMMAND REG and all the modulation registers to zero. |
| TEST | Test Mode. This used for factory test only and should be left as a No Connect. |

AD7008

## CIRCUIT DESCRIPTION

In contrast to previous direct digital synthesizer devices, the AD7008 provides an exciting new level of integration for the RF/Communications system designer. The AD7008 combines the numerical controlled oscillator (NCO), SIN/COSINE lookup tables, frequency, phase and IQ modulators, and a digital-to-analog converter on a single integrated circuit.
The internal circuitry of the AD7008 consists of four main sections. These are

Numerical Controlled Oscillator (NCO) + Phase Modulator
SIN and COSINE look up tables
In Phase and Quadrature Modulators
Digital-to-Analog Converter

## Numerical Controlled Oscillator + Phase Modulator

This consists of two frequency select registers, a phase accumulator and a phase offset register. The main component of the NCO is a 32 -bit phase accumulator which accumulates a phase step on every clock cycle. The value of the phase step determines how many clocks cycles are required for the phase accumulator to count $2 \pi$ radians (i.e., one cycle of the output frequency). The output frequency, $f_{\text {OUT }}$, is given by:

$$
\begin{gathered}
f_{\text {OUT }}=\frac{\text { Phase Step }}{2 \pi} f_{\text {CLOCK }}=\frac{\Delta \text { Phase }}{2^{32}} f_{\text {CLOCK }} \\
0 \leq \Delta \text { Phase } \leq 2^{32}-1
\end{gathered}
$$

The input to the phase accumulator (i.e., the phase step) can be selected either from the FREQ0 Register or FREQ1 Register and this is controlled by the FSELECT pin. This allows binary frequency shift keying to be easily implemented. The two FSK frequencies can be loaded into FREQ0 and FREQ1 and selected using the FSELECT pin. NCOs inherently generate continuous phase signals, thus avoiding any output discontinuity when switching between frequencies. More complex frequency modulation schemes, such as GMSK, can be implemented by updating the contents of these registers.
Following the NCO, a phase offset can be added to perform phase modulation using the 12 -bit PHASE Register. The contents of this register are added to the most significant bits of the NCO.
Sin and Cosine Look-Up Tables (LUT)
The output of the phase accumulator is converted to an amplitude signal by means of an Sine/Cosine ROM LUT. Although
the NCO contains a 32 -bit phase accumulator, the output of the NCO is truncated to 12 -bits. Using the full resolution of the phase accumulator is both impractical and unnecessary as this would require a look-up table of $2^{32}$ entries.
It is necessary only to have sufficient phase resolution in the LUTs such that the dc error of the output waveform is dominated by the quantization error in the DAC. This requires the look-up tables to have two more bits of phase resolution than the 10-bit DAC.

## In Phase and Quadrature Modulators

Two 10-bit amplitude multipliers are provided allowing the easy implementation of either Quadrature Amplitude Modulation (QAM) or Amplitude Modulation (AM). The 20-bit IQMOD Register is used to control the amplitude of the I (cosine) and Q (sine) signals. IQMOD[9-0] controls the I amplitude and IQMOD[19-10] controls the Q amplitude.
The user should ensure that when summing the $I$ and $Q$ signals the result should not exceed 10 -bits, as there is no internal clipping logic to prevent overflow.
When amplitude modulation is not required, the IQ multipliers can be bypassed $(C R 2=0)$. The sine output is directly sent to the 10 -bit DAC.

## Digital-to-Analog Converter

The AD7008 include a high impedance current source 10-bit DAC, capable of driving wide range of loads at different speeds. Full-scale output current can be adjusted, for opțimum power and external load requirements, through the use of a single external resistor ( $\mathbf{R}_{\text {SET }}$ ).
The DAC can be configured for single or differential ended operation. $\overline{\mathrm{I}_{\text {OUT }}}$ can be either tied directly to AGND for single ended operation or through external load resistor.

## MPU Interface

The chip contains two 32-bit assembly registers, one for parallel bus data, and one for serial input data. Each of the modulation registers can be loaded from either assembly register under control of the LOAD pin and the Transfer-Control (TC) pins (See Table I). The Command register can only be loaded from the parallel assembly register.

Table I. Source and Destination Registers

| TC3 | TC2 | TC1 | TC0 | LOAD | Source Register | Destination Register |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| $\mathbf{X}$ | $\mathbf{X}$ | $\mathbf{X}$ | $\mathbf{X}$ | 0 | N/A | N/A |
| 0 | 0 | $\mathbf{X}$ | $\mathbf{X}$ | 1 | Parallel | COMMAND |
| 1 | 0 | 0 | 0 | 1 | Parallel | FREQ0 |
| 1 | 0 | 0 | 1 | 1 | Parallel | FREQ1 |
| 1 | 0 | 1 | 0 | 1 | Parallel | PHASE |
| 1 | 0 | 1 | 1 | 1 | Parallel | IQMOD |
| 1 | 1 | 0 | 0 | 1 | Serial | FREQ0 |
| 1 | 1 | 0 | 1 | 1 | Serial | FREQ1 |
| 1 | 1 | 1 | 0 | 1 | Serial | PHASE |
| 1 | 1 | 1 | 1 | 1 | Serial | IQMOD |

Table II. AD7008 Control Registers

| Register | Size | Reset State | Description |
| :--- | :--- | :--- | :--- |
| COMMAND REG | 4 Bits CR3-CR0 | All Zeros | Command Register. This is written to using the parallel assembly register. <br> Frequency Select Register 0. This defines the output frequency, when |
| FREQ0 REG | 32 Bits DB31-DB0 | All Zeros | FSELECT = 0, as a fraction of the CLOCK frequency. <br> Frequency Select Register 1. This defines the output frequency, when |
| PHASE REG | 12 Bits DB11-DB0 | All Zeros | FSELECT = 1, as a fraction of the CLOCK frequency. <br> Phase Offset Register. The contents of this register is added to the <br> output of the phase accumulator. |
| IQMOD REG | 20 Bits DB19-DB0 | All Zeros | I and Q Amplitude Modulation Register. This defines the amplitude of <br> the I and Q signals as 10-bit two complement binary fractions. DB[19:10] <br> is multiplied by the Quadrature (sine component and DB[9:0] is multiplied <br> by the In-Phase (cosine) component. |

## Table III. Command Register Bits

| CR0 | $=0$ | Eight-Bit Databus. Pins D15-D8 are ignored and the parallel assembly register shifts eight places left on each write. <br> Hence four successive writes are required to load the 32-bit parallel assembly register, Figure 6. <br> Sixteen-Bit Databus. The parallel assembly register shifts 16 places left on each write. Hence two successive writes <br> are required to load the 32-bit parallel assembly register, Figure 5. |
| :--- | :--- | :--- |
| CR1 | $=0$ |  |
| CR2 | $=0$ |  |
| CR3 | $=0$ | Normal Operation. <br> Low Power Sleep Mode. Internal Clocks and the DAC current sources are turn off. <br> Amplitude Modulation Bypass. The output of the sine LUT is directly sent to the DAC. <br> Amplitude Modulation Enable. IQ modulation is enabled allowing AM or QAM to be performed. <br> Synchronizer Logic Enabled. The FSELECT, LOAD and TC3-TC0 signals are passed through a 4-stage pipeline <br> to synchronize them with the CLOCK frequency, avoiding metastability problems. <br> Synchronizer Logic Disabled. The FSELECT, LOAD and TC3-TC0 signals bypass the synchronization logic. This <br> allows for faster response to the control signals. |

TC3-TC0 should be set up and stable before LOAD rises, and should not change until after LOAD falls.
The microprocessor asserts both $\overline{\mathrm{WR}}$ and $\overline{\mathrm{CS}}$ to load the parallel assembly register. At the end of each write, the parallel assembly register is shifted left by 8 or 16 bits (depending on CR0), and the new data is loaded into the low bits. Hence, two 16-bit writes or four 8-bit writes are used to load the parallel assembly register. When loading parallel data destined for the phase or IQ registers, it is only necessary to write as much data as will be used by that register. For instance, the Command Register requires only one write to the parallel assembly register.
Serial data is input to the chip on the rising edge of SCLK, most significant bit first. The data in the assembly registers can be transferred to the modulation registers by means of the transfer control pins.

## APPLICATIONS

The AD7008 can be used in a wide range of communication applications ranging from digital mobile radio, to frequency agile Wireless Local Area Networks (WANs), to SSB telephony.
For digital mobile radio applications the chip provides direct synthesis and phase modulation capabilities to 20 MHz in a single low power, low cost part.
For WANs a wide range of modulation capabilities allow a system developer to optimize modulation bandwidth and noise immunity.
In the area of SSB telephony (military, commercial and amateur), the chip provides the first single chip implementation of a phasing type SSB generator. Combined with a single chip DSP (ADSP-2101) implementing the speech input and Hilbert transform, the AD7008 forms a two-chip direct SSB generation capability to over 20 MHz .


Figure 7. $f_{C L K}=20 \mathrm{MHz}, f_{O U T}=1.1 \mathrm{MHz}$


Figure 8. $f_{C L K}=20 \mathrm{MHz}, f_{O U T}=3.1 \mathrm{MHz}$


Figure 9. $f_{C L K}=20 \mathrm{MHz}, f_{\text {OUT }}=5.1 \mathrm{MHz}$


Figure 10. $f_{C L K}=20 \mathrm{MHz}, f_{\text {OUT }}=2.1 \mathrm{MHz}$


Figure 11. $f_{C L K}=20 \mathrm{MHz}, f_{O U T}=4.1 \mathrm{MHz}$


Figure 12. $f_{C L K}=20 \mathrm{MHz}, f_{O U T}=6.1 \mathrm{MHz}$


Figure 13. $f_{C L K}=20 \mathrm{MHz}, f_{O U T}=6.5 \mathrm{MHz}$


Figure 14. $f_{C L K}=50 \mathrm{MHz}, f_{O U T}=2.1 \mathrm{MHz}$


Figure 15. $f_{C L K}=50 \mathrm{MHz}, f_{O U T}=7.1 \mathrm{MHz}$


Figure 16. $f_{C L K}=20 \mathrm{MHz}, f_{O U T}=7.1 \mathrm{MHz}$


Figure 17. $f_{C L K}=50 \mathrm{MHz}, f_{O U T}=5.1 \mathrm{MHz}$


Figure 18. $f_{C L K}=50 \mathrm{MHz}, f_{O U T}=9.1 \mathrm{MHz}$


Figure 19. $f_{\text {CLK }}=50 \mathrm{MHz}, f_{\text {OUT }}=11.1 \mathrm{MHz}$


Figure 20. $f_{\text {CLK }}=50 \mathrm{MHz}, f_{\text {OUT }}=13.1 \mathrm{MHz}$


Figure 21. $f_{C L K}=50 \mathrm{MHz}, f_{\text {OUT }}=16.5 \mathrm{MHz}$


Figure 22. Typical Current Consumption vs. Frequency


Figure 23. Typical Plot of SFDR vs. Master Clock Frequency When $f_{\text {OUT }}=1 / 3 f_{\text {CLK, }}$, Frequency Word $=5671$ C71C HEX

## FEATURES

10ps Delay Resolution
2.5ns to $10 \mu$ sull-Scale Range

Fully Differential Inputs
Separate Trigger and Reset Inputs
Low Power Dissipation - 310mW
MIL-STD-883 Compliant Versions Available

## APPLICATIONS

## ATE

Pulse Deskewing
Arbitrary Waveform Generators
High-Stability Timing Source
Multiple Phase Clock Generators

## GENERAL DESCRIPTION

The AD9500 is a digitally programmable delay generator, which provides programmed delays, selected through an 8-bit digital code, in resolutions as small as 10 ps . The AD9500 is constructed in a high-performance bipolar process, designed to provide high-speed operation for both digital and analog circuits.
The AD9500 employs differential TRIGGER and RESET inputs which are designed primarily for ECL signal levels but function with analog and TTL input levels. An on-board ECL reference midpoint allows both of the inputs to be driven by either single ended or differential ECL circuits. The AD9500 output is a complementary ECL stage, which also provides a parallel $\overline{\mathbf{Q}_{\mathbf{R}}}$ output circuit to facilitate reset timing implementations.
The digital control data is passed to the AD9500 through a transparent latch controlled by the LATCH ENABLE signal. In the transparent mode, the internal DAC of the AD9500 will attempt to follow changes at the inputs. The LATCH ENABLE is otherwise used to strobe the digital data into the AD9500 latches.
The AD9500 is available as an industrial temperature range device, $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$, and as an extended temperature range device, $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. Both grades are packaged in a 24 -pin ceramic "Skinny" DIP ( 0.3 " package width), as well as 28 -pin surface mount packages. The AD9500 is available in versions compliant with MIL-STD-883. Refer to the Analog Devices Military Products Databook or current AD9500/883B data sheet for detailed specifications.

FUNCTIONAL BLOCK DIAGRAM


PIN CONFIGURATIONS

ABSOLUTE MAXIMUM RATINGS ${ }^{1}$
Positive Supply Voltage ( $+\mathrm{V}_{\mathrm{S}}$ ) ..... $+7 \mathrm{~V}$
Negative Supply Voltage ( $-\mathrm{V}_{\mathrm{S}}$ ) ..... $-7 \mathrm{~V}$
ECL COMMON to Ground Differential ..... -2.0 V to +5.0 V
Digital Input Voltage Range ..... -3.5 V to +5.0 V
Trigger/Reset Input Voltage Range ..... $\pm 5.0 \mathrm{~V}$
Trigger/Reset Differential Voltage ..... 5.0 V
Minimum $\mathrm{R}_{\text {SET }}$ ..... $220 \Omega$
Digital Output Current ( Q and $\overline{\mathrm{Q}}$ ) ..... 30 mA
Digital Output Current $\left(\overline{\mathbf{Q}_{\mathbf{R}}}\right)$ ..... 2 mA
Offset Adjust Current (Sinking)Operating Temperature Range
AD9500BP/BQAD9500TE/TQ . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range ..... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Junction Temperature ..... $+175^{\circ} \mathrm{C}$
Lead Soldering Temperature (10sec) ..... $+300^{\circ} \mathrm{C}$

FIFCTPICR СНАDACTEDICTICS (Supply Voltages $+V_{S}=+5.0 \mathrm{~V},-V_{S}=-5.2 V ; C_{E x T}=0 p F ; R_{\text {SEt }}=500 \Omega$, unless otherwise noted)

| Parameter | Test Level | Temp | $\begin{gathered} -25^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \\ \text { AD9500BP/BQ } \end{gathered}$ |  |  | $\begin{gathered} -55^{\circ} \mathrm{C} \text { to }+125^{\circ} \mathrm{C} \\ \text { AD } 9500 \mathrm{TE} / \mathrm{TQ} \end{gathered}$ |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max | Min | Typ | Max |  |
| RESOLUTION |  |  | 8 |  |  | 8 |  |  | Bits |
| ACCURACY ${ }^{3}$ |  |  |  |  |  |  |  |  |  |
| Differential Linearity | I | $+25^{\circ} \mathrm{C}$ |  |  | 0.5 |  |  | 0.5 | LSB |
| Integral Linearity | I | $+25^{\circ} \mathrm{C}$ |  |  | 1.0 |  |  | 1.0 | LSB |
| Monotonicity | I | $+25^{\circ} \mathrm{C}$ |  | Guaran |  |  | Guarant |  |  |
| DIGITAL INPUT |  |  |  |  |  |  |  |  |  |
| Logic "1" Voltage | VI | Full | 2.0 |  |  | 2.0 |  |  | V |
| Logic " 0 " Voltage | VI | Full |  |  | 0.8 |  |  | 0.8 | V |
| Logic " 1 " Current | VI | Full |  |  | 5 |  |  | 5 | $\mu \mathrm{A}$ |
| Logic " 0 " Current | VI | Full |  |  | 5 |  |  | 5 | $\mu \mathrm{A}$ |
| Digital Input Capacitance | VI | $+25^{\circ} \mathrm{C}$ |  |  | 5.5 |  |  | 5.5 | pF |
| Data Setup Time ${ }^{4}$ | V | $+25^{\circ} \mathrm{C}$ |  | 0.4 | 0.75 |  | 0.4 | 0.75 | ns |
| Data Hold Time ${ }^{5}$ | V | $+25^{\circ} \mathrm{C}$ |  | 0.4 | 0.75 |  | 0.4 | 0.75 | ns |
| Latch Pulse Width ( $\mathrm{t}_{\text {LPw }}$ ) | V | $+25^{\circ} \mathrm{C}$ | 3.0 |  |  | 3.0 |  |  | ns |
| RESET/TRIGGER INPUTS ${ }^{6}$ |  |  |  |  |  |  |  |  |  |
| TRIGGER Input Voltage Range | IV | Full |  | -2.5; |  |  | -2.5; |  | V |
| RESET Input Voltage Range | IV | Full |  | -2.5; |  |  | -2.5; |  | V |
| Differential Switching Voltage | IV | Full |  |  | 300 |  | 40 | 300 | mV |
| Input Bias Current | I | $+25^{\circ} \mathrm{C}$ |  |  | 50 |  |  | $50$ | $\mu \mathrm{A}$ |
|  | VI | Full |  |  | 75 |  |  | $75$ | $\mu \mathrm{A}$ |
| Input Resistance | IV | $+25^{\circ} \mathrm{C}$ |  | 4 |  |  | 4 |  | $\mathrm{k} \Omega$ |
|  | IV | $+25^{\circ} \mathrm{C}$ |  | 6.5 | 7.25 |  | 6.5 | 7.25 | pF |
|  |  |  |  |  |  |  |  |  |  |
| DYNAMIC PERFORMANCE ${ }^{7}$ |  |  |  |  |  |  |  |  |  |
| Maximum Trigger Rate | IV | $+25^{\circ} \mathrm{C}$ |  | 60 |  |  | 60 |  | MHz |
| Minimum Propagation Delay ( $\mathrm{tPD}^{\text {P }}{ }^{8}$ | I | $+25^{\circ} \mathrm{C}$ | 5.4 | 6.4 | 7.4 | 5.4 | 6.4 | 7.4 |  |
| Minimum Propagation Delay TC | V | Full |  | 7.5 |  |  | 7.5 |  | ps $/{ }^{\circ} \mathrm{C}$ |
| Full-Scale Range TC ${ }^{9}$ | V | Full |  | 0.5 |  |  | 0.5 |  | ps $/{ }^{\circ} \mathrm{C}$ |
| Delay Uncertainty (Jitter) | V | $+25^{\circ} \mathrm{C}$ |  | 10 |  |  | 10 |  | ps |
| Reset Propagation Delay ( $\left.\mathrm{t}_{\mathrm{RD}}\right)^{10}$ | I | $+25^{\circ} \mathrm{C}$ | 5.4 | 6.4 | 7.4 | 5.4 | 6.4 | 7.4 | ns |
| Reset-to-Trigger Holdoff ( $\left.\mathrm{t}_{\mathrm{THO}}\right)^{11}$ | IV | $+25^{\circ} \mathrm{C}$ | 0.2 | 0 |  | 0.2 | 0 |  | ns |
| Trigger-to-Reset Holdoff ( $\left.\mathrm{t}_{\mathrm{RHO}}\right)^{12}$ | IV | $+25^{\circ} \mathrm{C}$ | 2.0 | 1.5 |  | 2.0 | 1.5 |  | ns |
| Minimum Output Pulse Width | V | $+25^{\circ} \mathrm{C}$ |  | 3.3 |  |  | 3.3 |  | ns |
| Output Rise Time ${ }^{7}$ | 1 | $+25^{\circ} \mathrm{C}$ |  |  | 2.0 |  |  | 2.0 | ns |
| Output Fall Time ${ }^{7}$ | 1 | $+25^{\circ} \mathrm{C}$ |  |  | 2.0 |  |  | 2.0 | ns |
| Delay Coefficient Settling Time ( $\left.\mathrm{t}_{\text {DAC }}\right)^{13}$ | V | $+25^{\circ} \mathrm{C}$ |  | 29 |  |  | 29 |  | ns |
| Linear Ramp Settling Time ( $\mathrm{t}_{\text {LRS }}$ ) | V | $+25^{\circ} \mathrm{C}$ |  | 22 |  |  | 22 |  | ns |

AD9500

| Parameter | Test Level | Temp | $\begin{gathered} -25^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \\ \text { AD9500BP/BQ } \end{gathered}$ |  |  | $\begin{gathered} -55^{\circ} \mathrm{C} \text { to }+125^{\circ} \mathrm{C} \\ \text { AD } 9500 \mathrm{TE} / \mathrm{TQ} \end{gathered}$ |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max | Min | Typ | Max |  |
| SUPPORT FUNCTIONS |  |  |  |  |  |  |  |  |  |
| ECL ${ }_{\text {ReF }}$ | IV | $+25^{\circ} \mathrm{C}$ | -1.4 | -1.3 | -1.2 | -1.4 | -1.3 | -1.2 | V |
| ECL ${ }_{\text {ReF }}$ Voltage Drift ${ }^{1+}$ | V | Full |  | 1.1 |  |  | 1.1 |  | $\mathrm{mV} /{ }^{\circ} \mathrm{C}$ |
| Offset Adjust Range | V | Full |  | -2 |  |  | -2 |  | mA |
| DIGITAL OUTPUTS ${ }^{7}$ |  |  |  |  |  |  |  |  |  |
| Logic " 1 " Voltage | VI | Full | -1.1 |  |  | $-1.1$ |  |  | V |
| Logic " 0 " Voltage | VI | Full |  |  | -1.5 |  |  | -1.5 | V |
| POWER SUPPLY ${ }^{15}$ |  |  |  |  |  |  |  |  |  |
| Positive Supply Current ( +5.0 V ) | I | $+25^{\circ} \mathrm{C}$ |  | 24 | 28 |  | 24 | 28 | mA |
|  | VI | Full |  |  | 30 |  |  | 30 | mA |
| Negative Supply Current (-5.2V) | I | $+25^{\circ} \mathrm{C}$ |  | 37 | 42 |  | 37 | 42 | mA |
|  | VI | Full |  |  | 44 |  |  | 44 | mA |
|  | V | $+25^{\circ} \mathrm{C}$ |  | 312 |  |  | 312 |  | mW |
| Power Supply Rejection Ratio ${ }^{16}$ |  |  |  |  |  |  |  |  |  |
| Full-Scale Range Sensitivity | I | $+25^{\circ} \mathrm{C}$ |  | 70 | 300 |  | 70 | 300 | ps/V |
| Minimum Propagation Delay Sensitivity | I | $+25^{\circ} \mathrm{C}$ |  | 150 | 500 |  | 150 | 500 | ps/V |

## NOTES

${ }^{1}$ Absolute maximum ratings are limiting values, to be applied individually, and beyond which serviceability of the circuit may be impaired. Functional operability under any of these conditions is not necessarily implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
${ }^{2}$ Typical thermal impedance
24-Pin Ceramic $\quad \theta_{\mathrm{JA}}=56^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=16^{\circ} \mathrm{C} / \mathrm{W}$
28-Pin PLCC (Plastic) $\quad \theta_{\mathrm{JA}}=60^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=22^{\circ} \mathrm{C} / \mathrm{W}$
28-Pin Ceramic LCC $\quad \theta_{\mathrm{JA}}=69^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=25^{\circ} \mathrm{C} / \mathrm{W}$
${ }^{3} \mathrm{R}_{\text {SET }}=10 \mathrm{k} \Omega$ (Full-scale delay $=100 \mathrm{~ns}$ ).
${ }^{4}$ The digital data inputs must remain stable for the specified time prior to the LATCH ENABLE signal.
${ }^{5}$ The digital data inputs must remain stable for the specified time after the LATCH ENABLE signal.
${ }^{6}$ The TRIGGER and RESET inputs are differential and must be driven relative to one another. Both of these inputs are ECL compatible, but can also be used with TTL logic families in a limited fashion.
${ }^{7}$ Outputs terminated through $50 \Omega$ resistors to -2.0 V .
${ }^{8}$ Program Delay $=0.0 \mathrm{ps}\left(\right.$ Digital Data $\left.=00_{\mathrm{H}}\right)$. In Operation, any programmed delays are in addition to the Minimum Propagation Delay. ${ }^{9}$ Change in total delay through AD9500, exclusive of changes in minimumpropagation delay $\mathrm{t}_{\text {PD }}$.
${ }^{10}$ Measured from the $50 \%$ transition point of the reset signal input, to the $50 \%$ transition point of the resetting output.
${ }^{11}$ Minimum time from falling edge of RESET to triggering input, to insure a valid output event.
${ }^{12}$ Minimum time from triggering event to rising edge of RESET, to insure a valid output event.
${ }^{13}$ Measured from the LATCH ENABLE input to the point when the AD9500 becomes 8-bit accurate again, after a full-scale change in the programmed delay.
${ }^{14}$ Standard 10 K and 10 KH ECL families operate with a $1.1 \mathrm{mV} /{ }^{\circ} \mathrm{C}$ drift by design.
${ }^{15}$ Supply voltages should remain stable within $\pm 5 \%$ for normal operation.
${ }^{16}$ Measured at $\pm 5 \%$ of $-V_{S}$ and $+V_{S}$.
Specifications subject to change without notice.

## EXPLANATION OF TEST LEVELS

## Test Level

I - $100 \%$ production tested.
II - $100 \%$ production tested at $+25^{\circ} \mathrm{C}$, and sample tested at specified temperatures.
III - Periodically sample tested.
IV - Parameter is guaranteed by design and characterization testing.
V - Parameter is a typical value only.
VI - All devices are $100 \%$ production tested at $+25^{\circ} \mathrm{C} .100 \%$ production tested at temperature extremes for extended temperature devices; sample tested at temperature extremes for commercial/industrial devices.

ORDERING GUIDE

|  |  |  | Package <br> Options* |
| :--- | :--- | :--- | :--- |
| Model | Temperature Range | Description | $\mathrm{P}-28 \mathrm{~A}$ |
| AD9500BP | $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 28-Pin PLCC(Plastic), Industrial Temperature | $\mathrm{Q}-24$ |
| AD9500BQ | $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 24-Pin "Skinny"DIP, Industrial Temperature | $\mathrm{E}-28 \mathrm{~A}$ |
| AD9500TE | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 28-Pin LCC, Extended Temperature | Q -24 |
| AD9500TQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 24-Pin "Skinny"DIP, Extended Temperature |  |

*E = Leadless Ceramic Chip Carrier; $\mathbf{P}=$ Plastic Leaded Chip Carrier; $\mathbf{Q}=$ Cerdip. For outline information see Package Information section.

## FUNCTIONAL DESCRIPTION

| PIN NAME | DESCRIPTION |
| :---: | :---: |
| $\mathrm{D}_{4}-\mathrm{D}_{6}$ | - One of eight digital inputs used to set the programmed delay. |
| $\mathrm{D}_{7}$ (MSB) | - One of eight digital inputs used to set the programmed delay. $\mathrm{D}_{7}$ (MSB) is the most significant bit of the digital input word. |
| ECL ${ }_{\text {REF }}$ | - ECL midpoint reference, nominally -1.3 V . Use of the ECL $_{\text {REF }}$, allows either of the TRIGGER or the RESET inputs to be configured for single-ended ECL inputs. |
| OFFSET ADJUST | - The OFFSET ADJUST is used to adjust the minimum propagation delay ( $\mathrm{t}_{\text {PD }}$ ), by pulling or pushing a small current out of or into the pin. |
| $\mathrm{C}_{\text {s }}$ | $-\mathrm{C}_{S}$ allows the full-scale range to be extended by using an external timing capacitor. The value of $\mathrm{C}_{\mathrm{EXT}}$, connected between $\mathrm{C}_{\mathrm{S}}$ and $+\mathrm{V}_{\mathrm{S}}$, may range from no external capacitance to $0.1 \mu \mathrm{~F}+$. See $R_{S}\left(C_{\text {internal }}=10 \mathrm{pF}\right)$. |
| $+V_{s}$ | - Positive supply terminal, nominally +5.0 V . |
| TRIGGER | - Noninverted input of the edge-sensitive differential trigger input stage. The output at $Q$ will be delayed by the programmed delay, after the triggering event. The programmed delay is set by the digital input word. The TRIGGER input must be driven in conjunction with the TRIGGER input. |
| TRIGGER | - Inverted input of the edge-sensitive differential trigger input stage. The output at $\mathbf{Q}$ will be delayed by the programmed delay, after the triggering event. The programmed delay is set by the digital input word. The TRIGGER input must be driven in conjunction with the TRIGGER input. |
| RESET | - Inverted input of the level-sensitive differential reset input stage. The output at Q will be reset after a signal is received at the reset inputs. In the "minimum configuration," the minimum output pulse width will be equal to the "reset propagation delay," $t_{\text {RD }}$. The RESET input must be driven in conjunction with the RESET input. |
| RESET | - Noninverted input of the level-sensitive differential reset input stage. The output at $\mathbf{Q}$ will be reset after a signal is received at the reset inputs. In the "minimum configuration," the minimum output pulse width will be equal to the "reset propagation delay," $t_{\text {RD }}$. The RESET input must be driven in conjunction with the RESET input. |
| Q | - One of two complementary ECL outputs. A "triggering" event at the inputs will produce a logic HIGH on the Q output. A "resetting" event at the inputs will produce a logic LOW on the Q output |
| $\overline{\mathbf{Q}}$ | - One of two complementary ECL outputs. A "triggering" event at the inputs will produce a logic LOW on the $\bar{Q}$ output. A "resetting" event at the inputs will produce a logic HIGH on the $\overline{\mathbf{Q}}$ output. |
| $\overline{\mathrm{Q}_{\mathrm{R}}}$ | $-\overline{Q_{R}}$ output is parallel to the $\overline{\mathrm{Q}}$ output. The $\overline{\mathrm{Q}_{\mathrm{R}}}$ output is typically used to drive delaying circuits for extending output pulse widths. A "triggering" event at the inputs will produce a logic LOW on the $\overline{Q_{R}}$ output. A "resetting" event at the inputs will produce a logic HIGH on the $\overline{Q_{R}}$ output. |
| ECLCOMMON | - The collector common for the ECL output stage. The collector common may be tied to +5.0 V , but normally it is tied to the circuit ground for standard ECL outputs. |
| $-\mathrm{V}_{\text {S }}$ | - Negative supply terminal, nominally -5.2V. |
| Rs | - $\mathbf{R}_{\mathrm{S}}$ is the reference current setting terminal. An external setting resistor, $\mathbf{R}_{\text {SET }}$, connected between $R_{S}$ and $-V_{S}$ determines the internal reference current. See $C_{S}\left(250 \Omega \leq R_{S E T} \leq 50 k \Omega\right)$. |
| GROUND | - The ground return for the TTL and analog inputs. |
| LATCH ENABLE | - Transparent TTL latch control line. A logic HIGH on the LATCH ENABLE freezes the digital code at the logic inputs. A logic LOW on the LATCH ENABLE allows the internal current levels to be continuously updated through the logic inputs $\mathrm{D}_{0}$ thru $\mathrm{D}_{7}$. |
| $\mathrm{D}_{0}$ (LSB) | - One of eight digital inputs used to set the programmed delay. $\mathrm{D}_{0}$ (LSB) is the least significant bit of the digital input word. |
| $\mathrm{D}_{3}-\mathrm{D}_{1}$ | - One of eight digital inputs used to set the programmed delay. |

FEATURES
Single +5 V Supply
TTL and CMOS Compatible
10 ps Delay Resolution
2.5 ns to $10 \mu$ s Full-Scale Range

Maximum Trigger Rate 50 MHz
MIL-STD-883-Compliant Versions Available

## APPLICATIONS

Disk Drive Deskewing
Data Communications
Test Equipment
Radar I \& Q Matching

## GENERAL DESCRIPTION

The AD9501 is a digitally programmable delay generator which provides programmed time delays of an input pulse. Operating from a single +5 V supply, the AD9501 is TTL- or CMOScompatible, and is capable of providing accurate timing adjustments with resolutions as low as 10 ps . Its accuracy and programmability make it ideal for use in data deskewing and pulse delay applications, as well as clock timing adjustments.
Full-scale delay range is set by the combination of an external resistor and capacitor, and can range from 2.5 ns to $10 \mu \mathrm{~s}$ for a single AD9501. An eight-bit digital word selects a time delay

FUNCTIONAL BLOCK DIAGRAM

within the full-scale range. When triggered by the rising edge of an input pulse, the output of the AD9501 will be delayed by an amount equal to the selected time delay ( $\mathrm{t}_{\mathrm{D}}$ ) plus an inherent propagation delay ( $\mathrm{t}_{\mathrm{PD}}$ ).
The AD9501 is available for a commercial temperature range of $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ in a 20 -pin plastic DIP, 20-pin ceramic DIP, and a 20 -lead plastic leaded'chip carrier (PLCC). Devices fully compliant to MIL-STD-883 are available in ceramic DIPs. Refer to the Analog Devices Military Products Databook or current AD9501/883B data sheet for detailed specifications.

## AD9501-SPECIFICATIONS

ABSOLUTE MAXIMUM RATINGS ${ }^{1}$

| Positive Supply Voltage |  |
| :---: | :---: |
| Digital Input Voltage Range | -0.5 V to $+\mathrm{V}_{\mathrm{S}}$ |
| Trigger/Reset Input Volt. Range | -0.5 V to $+\mathrm{V}_{\mathrm{S}}$ |
| Minimum $\mathrm{R}_{\text {SET }}$ | $30 \Omega$ |
| Digital Output Current (Sourcing) | 0 mA |
| Digital Output Current (Sinking) | 50 mA |


| Operating Temperature Range |  |
| :---: | :---: |
| AD9501JN/JP/JQ | to $+70^{\circ} \mathrm{C}$ |
| AD9501SQ | $55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Storage Temperature Range . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |  |
| Junction Temperature ${ }^{2}$ | $+175^{\circ} \mathrm{C}$ |
| Lead Soldering Temperature ( 10 sec ) | $+300^{\circ} \mathrm{C}$ |

FIECTRICAL CHARACTERISTICS ${ }^{[ }+V_{s}=+5 V_{;} C_{\text {ext }}=0$ pen; $R_{\text {seft }}=3090 \Omega$ (Full-scale range $=100$ ns); Pin 8 grounded; and device output connected to Pin 4 RESET input unless otherwise noted]


## NOTES

${ }^{1}$ Absolute maximum ratings are limiting values, to be applied individually, and beyond which the serviceability of the circuit may be impaired. Functional operability is not necessarily implied. Exposure to absolute maximum rating conditions for an extended period of time may affect device reliability.
${ }^{2}$ Typical thermal impedances: 20-lead plastic leaded chip carrier $\theta_{\mathrm{JA}}=73^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=29^{\circ} \mathrm{C} / \mathrm{W}$. 20-pin ceramic DIP $\theta_{\mathrm{JA}}=65^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=20^{\circ} \mathrm{C} / \mathrm{W}$.
20 -pin plastic DIP $\theta_{\mathrm{JA}}=65^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=26^{\circ} \mathrm{C} / \mathrm{W}$.
${ }^{3}$ Digital data inputs must remain stable for the specified time prior to the positive transition of the LATCH signal.
${ }^{4}$ Digital data inputs must remain stable for the specified time after the positive transition of the LATCH signal.
${ }^{\text {S }}$ Programmed delay $\left(\mathrm{t}_{\mathrm{D}}\right)=0 \mathrm{~ns}$. Maximum self-resetting trigger rate is limited to 6.9 MHz with 100 ns programmed delay. If $\mathrm{t}_{\mathrm{D}}=0 \mathrm{~ns}$ and external RESET signal is used, maximum trigger rate is 23 MHz .
${ }^{6}$ Programmed delay $\left(\mathrm{t}_{\mathrm{D}}\right)=0 \mathrm{~ns}$. In operation, any programmed delays are in addition to the minimum propagation delay ( $\mathrm{t}_{\mathrm{PD}}$ ).
${ }^{7}$ Programmed delay $\left(\mathrm{t}_{\mathrm{D}}\right)=0 \mathrm{~ns}$. [Minimum propagation delay $\left(\mathrm{t}_{\mathrm{PD}}\right)$ ]
${ }^{8}$ Measured from $50 \%$ transition point of the RESET signal input to the $50 \%$ transition point of the falling edge of the output.
${ }^{9}$ Minimum time from the falling edge of RESET to the triggering input to insure valid output pulse, using external RESET pulse.
${ }^{10}$ Minimum time from triggering event to rising edge of RESET to insure valid output event, using external RESET pulse. Extends to 125 ns when programmed delay is 100 ns .
${ }^{11}$ When self-resetting with a full-scale programmed delay.
${ }^{12}$ Measured from +0.4 V to +2.4 V ; source $=1 \mathrm{~mA}$; sink $=4 \mathrm{~mA}$.
${ }^{13}$ Measured from the data input to the time when the AD9501 becomes 8 -bit accurate, after a full-scale change in the program delay data word.
${ }^{14}$ Measured from the RESET input to the time when the AD9501 becomes 8 -bit accurate, after a full-scale programmed delay.
${ }^{15}$ Supply voltage should remain stable within $\pm 5 \%$ for normal operation.
${ }^{16}$ Measured at $+\mathrm{V}_{\mathrm{s}}=+5.0 \mathrm{~V} \pm 5 \%$; specification shown is for worst case.
Specifications subject to change without notice.

## EXPLANATION OF TEST LEVELS

## Test Level

I - $100 \%$ production tested.
II - $100 \%$ production tested at $+25^{\circ} \mathrm{C}$, and sample tested at specified temperatures.

III - Sample tested only.
IV - Parameter is guaranteed by design and characterization testing.
V - Parameter is a typical value only.
VI - All devices are $100 \%$ production tested at $+25^{\circ} \mathrm{C}$. $100 \%$ production tested at temperature extremes for extended temperature devices; sample tested at temperature extremes for commercial/industrial devices.

ORDERING GUIDE

| Device | Temperature | Description | Package <br> Option |
| :--- | :--- | :--- | :--- |
| AD9501JN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 20-Pin Plastic DIP | $\mathrm{N}-20$ |
| AD9501JP | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 20-Lead PLCC | $\mathrm{P}-20 \mathrm{~A}$ |
| AD9501JQ | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 20-Pin Ceramic DIP | $\mathrm{Q}-20$ |
| AD9501SQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 20-Pin Ceramic DIP | $\mathrm{Q}-20$ |

${ }^{\star} \mathrm{N}=$ Plastic DIP; $\mathbf{P}=$ Plastic Leaded Chip Carrier; $\mathrm{Q}=$ Cerdip. For outline information see Package Information section.

## DIE LAYOUT AND MECHANICAL INFORMATION



## MECHANICAL INFORMATION

Die Dimensions . . . . . . . . . . . . . . $89 \times 153 \times 15( \pm 2)$ mils Pad Dimensions. . . . . . . . . . . . . . . . . . . . . . . . . $4 \times 4$ mils Metalization. . . . . . . . . . . . . . . . . . . . . . . . . . . Aluminum Backing . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . .None Substrate Potential . . . . . . . . . . . . . . . . . . . . . . . . .Ground Passivation . . . . . . . . . . . . . . . . . . . . . . . . . . . .Oxynitride Die Attach . . . . . . . . . . . . . . . . . . . . . . . . . .Gold Eutectic Bond Wire . . . . . . . . 1.25 mil, Aluminum; Ultrasonic Bonding or 1 mil, Gold; Gold Ball Bonding

## AD9501 PIN DESCRIPTIONS

| Pin No. | Name | Function |
| :---: | :---: | :---: |
| 1 | $+\mathrm{V}_{\mathrm{S}}$ | Positive voltage supply; nominally +5 V . |
| 2 | LATCH | TTL/CMOS register control line. Logic HIGH latches input data $D_{0}-D_{7}$. Register is transparent for logic LOW. |
| 3 | TRIGGER | TTL/CMOS-compatible input. Rising edge triggers the internal ramp generator, and begins the delay cycle. |
| 4 | RESET | TTL/CMOS-compatible input. Logic HIGH resets the ramp voltage and OUTPUT. |
| 5 | DAC OUTPUT | Output voltage of the internal digital-to-analog converter. |
| 6 | $\mathrm{C}_{\text {EXt }}$ | Optional external capacitor connected to $+\mathrm{V}_{\mathrm{S}}$; used with $\mathrm{R}_{\mathrm{SET}}$ and 8.5 pF internal capacitor to determine full-scale delay range ( $\mathrm{t}_{\mathrm{DFS}}$ ). |
| 7 | $\mathrm{R}_{\text {SET }}$ | External resistor to ground, used to determine full-scale delay range ( $t_{\text {DFS }}$ ). |
| 8 | OFFSET ADJUST | Normally connected to GROUND. Can be used to adjust minimum propagation delay ( $\mathrm{t}_{\mathrm{PD}}$ ); see Theory of Operation text. |
| 9 | GROUND | Circuit ground return. |
| 10 | OUTPUT | TTL-compatible delayed output pulse. |
| 11 | $+\mathrm{V}_{\text {S }}$ | Positive voltage supply; nominally +5 V . |
| 12-19 | $\mathrm{D}_{0}-\mathrm{D}_{7}$ | TTL/CMOS-compatible inputs, used to set the programmed delay of the AD9501 delayed output. $\mathrm{D}_{0}$ is LSB and $\mathrm{D}_{7}$ is MSB. |
| 20 | GROUND | Circuit ground return. |



## FEATURES

Phase and Frequency Detection
ECL/TTL/CMOS Compatible
Linear Transfer Function
No "Dead Zone"
MIL-STD-883 Compliant Versions Available
APPLICATIONS
Low Phase Noise Reference Loops
Fast-Tuning "Agile" IF Loops
Secure "Hopping" Communications
Coherent Radar Transmitter/Receiver Chains

## GENERAL DESCRIPTION

The AD9901 is a digital phase/frequency discriminator capable of directly comparing phase/frequency inputs up to 200 MHz . Processing in a high speed trench-oxide isolated process, combined with an innovative design, gives the AD9901 a linear detection range, free of indeterminate phase detection zones common to other digital designs.
With a single +5 V supply, the AD9901 can be configured to operate with TTL or CMOS logic levels; it can also operate with ECL inputs when operated with a -5.2 V supply. The opencollector outputs allow the output swing to be matched to postfiltering input requirements. A simple current setting resistor controls the output stage current range, permitting a reduction in power when operated at lower frequencies.

PHASE-LOCKED LOOP

REFERENCE INPUT


A major feature of the AD9901 is its ability to compare phase/frequency inputs at standard IF frequencies without prescalers. Excessive phase uncertainty which is common with standard PLL configurations is also eliminated. The AD9901 provides the locking speed of traditional phase/frequency discriminators, with the phase stability of analog mixers.
The AD9901 is available as a commercial temperature range device, $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$, and as a military temperature device, $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. The commercial versions are packaged in a 14 -pin ceramic DIP and a 20-pin PLCC.
The AD9901 Phase/Frequency Discriminator is available in versions compliant with MIL-STD-883. Refer to the Analog Devices Military Products Databook or current AD9901/883B data sheet for specifications.

FUNCTIONAL BLOCK DIAGRAM


This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.
ABSOLUTE MAXIMUM RATINGS ${ }^{\mathbf{1}}$
Positive Supply Voltage ( $+\mathrm{V}_{\mathrm{S}}$ for TTL Operation) $\ldots . . .+7 \mathrm{~V}$
Negative Supply Voltage ( $-\mathrm{V}_{\mathrm{S}}$ for ECL Operation) $\ldots . . .-7 \mathrm{~V}$
Input Voltage Range (TTL Operation) . . . . . . . 0 V to +5.5 V
Differential Input Voltage (ECL Operation) . . . . . . . . 4.0 V
$\mathrm{I}_{\text {SET }}$ Current . . . . . . . . . . . . . . . . . . . . . . . . 12 mA
Output Current . . . . . . . . . . . . . . . . . . . . . . 30mA

| Operating Temperature Range |  |
| :---: | :---: |
| AD9901KQ/KP | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ |
| Storage Temperature Range . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |  |
| Junction Temperature ${ }^{2}$ |  |
| Plastic | $+150^{\circ} \mathrm{C}$ |
| Ceramic | $+175^{\circ} \mathrm{C}$ |
| Lead Soldering Temperature (10sec) | $+300^{\circ} \mathrm{C}$ |

ELECTRICAL CHARACTERISTICS $\left( \pm V_{s}=+5.0 \mathrm{~V}\right.$ [for TTL] or -5.2 V [for ECL], unless otherwise noted)

|  |  |  |  | rcial Te ${ }^{\circ} \mathrm{C}$ to +7 D9901K |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Temp | Level | Min | Typ | Max | Units |
| INPUT CHARACTERISTICS |  |  |  |  |  |  |
| TTL Input Logic " 1 " Voltage | Full | VI | 2.0 |  |  | V |
| TTL Input Logic " 0 " Voltage | Full | VI |  |  | 0.8 | V |
| TTL Input Logic " 1 " Current ${ }^{3}$ | Full | VI |  |  | 0.6 | mA |
| TTL Input Logic "0" Current ${ }^{3}$ | Full | VI |  |  | 1.6 | mA |
| ECL Differential Switching Volt. | Full | VI | 300 |  |  | mV |
| ECL Input Current | Full | VI |  |  | 20 | $\mu \mathrm{A}$ |
| OUTPUT CHARACTERISTICS |  |  |  |  |  |  |
| Peak-to-Peak Output Voltage Swing ${ }^{4}$ | Full | VI | 1.6 | 1.8 | 2.0 | V |
| TTL Output Compliance Range | Full | V |  | 3-7. |  | V |
| ECL Output Compliance Range | Full | V |  | $\pm 2$ |  | V |
| $\mathrm{I}_{\text {Out }}$ Range | Full | V |  | 0.9-11 |  | mA |
| Internal Reference Voltage | Full | VI | 0.42 | 0.47 | 0.52 | V |
| AC CHARACTERISTICS |  |  |  |  |  |  |
| Linear Phase Detection Range ${ }^{4}$ |  |  |  |  |  |  |
| 40 kHz | $+25^{\circ} \mathrm{C}$ | V |  | 360 |  | Degrees |
| 30 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 320 |  | Degrees |
| 70 MHz | $+25^{\circ} \mathrm{C}$ | V |  | 270 |  | Degrees |
| Functionality @ 70MHz | $+25^{\circ} \mathrm{C}$ | I |  | Pass/Fai |  |  |
| POWER SUPPLY CHARACTERISTICS |  |  |  |  |  |  |
| TTL Supply Current ( $+5.0 \mathrm{~V})^{5,6}$ | $+25^{\circ} \mathrm{C}$ | I |  | 43.5 | 54.0 | mA |
|  | Full | I |  | 43.5 | 54.0 | mA |
| ECL Supply Current (-5.2V) ${ }^{\text {5, } 6}$ | $+25^{\circ} \mathrm{C}$ | I |  | 42.5 | 52.5 | mA |
|  | Full | I |  | 42.5 | 52.5 | mA |
| Nominal Power Dissipation | $+25^{\circ} \mathrm{C}$ | V |  | 218 |  | mW |

NOTES
${ }^{1}$ Absolute maximum ratings are limiting values, to be applied individually, and beyond which the serviceability of the circuit may be impaired. Functional operability is not necessarily implied. Exposure to absolute maximum rating conditions for an extended period of time may affect device reliability.
${ }^{2}$ Maximum junction temperature should not exceed $+175^{\circ} \mathrm{C}$ for ceramic packages, $+150^{\circ} \mathrm{C}$ for plastic packages. Junction temperature can be calculated by:

$$
\mathbf{t}_{\mathbf{t}}=\mathbf{P D}\left(\theta_{\mathrm{JA}}\right)+\mathrm{t}_{\mathrm{A}}=\mathrm{PD}\left(\theta_{\mathrm{JC}}\right)+\mathrm{t}_{\mathrm{C}}
$$

## where:

PD $=$ power dissipation
$\theta_{\mathrm{JA}}=$ thermal impedance from junction to air $\left({ }^{\circ} \mathrm{C} / \mathrm{W}\right)$
$\theta_{\mathrm{JC}}=$ thermal impedance from junction to case ( ${ }^{\circ} \mathrm{C} / \mathrm{W}$ )
$\mathrm{t}_{\mathrm{A}}=$ ambient temperature $\left({ }^{\circ} \mathrm{C}\right)$
$\mathrm{t}_{\mathrm{C}}=$ case temperature $\left({ }^{\circ} \mathrm{C}\right)$
typical thermal impedances:

$$
\text { AD9901 Ceramic DIP }=\theta_{\mathrm{IA}}=74^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=21^{\circ} \mathrm{C} / \mathrm{W}
$$

AD9901 LCC $=\theta_{\mathrm{JA}}=80^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=10^{\circ} \mathrm{C} / \mathrm{W}$
AD9901 PLCC $=\theta_{\mathrm{JA}}=88.2^{\circ} \mathrm{C} / \mathrm{W} ; \theta_{\mathrm{JC}}=45.2^{\circ} \mathrm{C} / \mathrm{W}$
${ }^{3} \mathrm{~V}_{\mathrm{L}}=+0.4 \mathrm{~V} ; \mathrm{V}_{\mathrm{H}}=+2.4 \mathrm{~V}$.
${ }^{4} \mathrm{R}_{\mathrm{SET}}=47.5 \Omega ; \mathrm{R}_{\mathrm{L}}=182 \Omega$.
${ }^{5}$ Includes load current of 10 mA (load resistors $=182 \Omega$ ).
${ }^{6}$ Supply should remain stable within $\pm 5 \%$ for normal operation.
Specifications subject to change without notice.

ORDERING GUIDE

| Model | Temperature | Description | Package Option ${ }^{1}$ |
| :---: | :---: | :---: | :---: |
| AD9901KQ | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 14-Pin Ceramic DIP | Q-14 |
| AD9901KP | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 20-Pin PLCC | P-20A |
| AD9901TQ/883 ${ }^{2}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 14-Pin Ceramic DIP | Q-14 |
| AD9901TE/883 ${ }^{2}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 20-Contact Ceramic LCC | E-20A |

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## EXPLANATION OF TEST LEVELS

Test Level
I - $100 \%$ production tested.
II - $100 \%$ production tested at $+25^{\circ} \mathrm{C}$, and sample tested at specified temperatures.
III - Sample tested only.
IV - Parameter is guaranteed by design and characterization testing.

V - Parameter is a typical value only.
VI - All devices are $100 \%$ production tested at $+25^{\circ} \mathrm{C}$.
$100 \%$ production tested at temperature extremes for extended temperature devices; sample tested at temperature extremes for commercial/industrial devices.

## PIN CONFIGURATIONS

TTL DIP Pinouts


TTL LCC Pinouts


TTL PLCC Pinouts


ECL DIP Pinouts


ECL LCC Pinouts


ECL PLCC Pinouts


## AD9955

## FEATURES

85 MHz Minimum Clock Rate
32-Bit Phase Accumulator
12-Bit Sine Output
$>90 \mathrm{~dB}$ Spurious Free Dynamic Range
Continuous Frequency Update
On-Board Data Ready Signal

## APPLICATIONS

Frequency Synthesizers
DDS Tuning
Digital Demodulation
FM Modulators

## GENERAL DESCRIPTION

The AD9955 is a 85 MHz direct digital synthesizer for frequency synthesis applications. It comprises a 32 -bit phase accumulator and a 15 -bit phase-to-12-bit sine amplitude converter. The control logic is CMOS compatible, and the clock input is TTL. CMOS outputs are latched on board, and a data ready signal is provided.
Designed for applications in communications, instrumentation, and military systems, the AD9955 can be combined with a clock reference and a DAC such as the AD9713B or AD9721 to form a digitally-controlled analog frequency reference.
The AD9955 is available in an 80 -lead plastic quad flatpack (PQFP) for commercial $\left(0^{\circ} \mathrm{C}\right.$ to $\left.+70^{\circ} \mathrm{C}\right)$ temperature range applications. Contact the factory for information concerning the availability of a military temperature range device.

FUNCTIONAL BLOCK DIAGRAM


ELECTRICAL CHARACTERISTICS $\left(+V_{S}=+5 \mathrm{~V} ; \mathrm{f}_{\mathrm{cLx}}=40 \mathrm{MHz} ; \mathrm{C}_{\mathrm{L}}=20 \mathrm{pF}\right.$, unless otherwise noted)

| Parameter (Conditions) | Temperature | Test Level | Min | $\begin{aligned} & \text { AD9955 } \\ & \text { Typ } \end{aligned}$ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| CMOS INPUTS ${ }^{1}$ |  |  |  |  |  |  |
| Logic " 1 " Voltage | Full | II | 3.5 |  |  | V |
| Logic "0" Voltage | Full | II |  |  | 1.5 | V |
| Logic " 1 " Current | Full | II |  |  | 1.0 | $\mu \mathrm{A}$ |
| Logic "0" Current | Full | II |  |  | -1.0 | $\mu \mathrm{A}$ |
| Input Capacitance | $+25^{\circ} \mathrm{C}$ | V |  | 10 |  | pF |
| CMOS OUTPUTS |  |  |  |  |  |  |
| Logic " 1 " Voltage ( $\mathrm{V}_{\mathbf{1 H}}$ ) | Full | II | 4.5 |  |  | V |
| Logic "0" Voltage ( $\mathrm{V}_{\mathrm{IL}}$ ) | Full | II |  |  | 0.4 | V |
| Logic " 1 " Current | Full | II |  |  | 12 | mA |
| Logic " 0 " Current | Full | II |  |  | 12 | mA |
| Output Capacitance | $+25^{\circ} \mathrm{C}$ | V |  | 3 |  | pF |
| TTL INPUTS ${ }^{2}$ |  |  |  |  |  |  |
| Logic "1" Voltage | Full | IV | 2.0 |  |  | V |
| Logic " 0 " Voltage | Full | II |  |  | 0.8 | V |
| Logic "l" Current | Full | II |  |  | 1.0 | $\mu \mathrm{A}$ |
| Logic "0" Current | Full | II |  |  | -1.0 | $\mu \mathrm{A}$ |
| Input Capacitance | $+25^{\circ} \mathrm{C}$ | V |  | 4 |  | pF |
| POWER SUPPLIES |  |  |  |  |  |  |
| $+V_{\text {S }}$ Current ${ }^{3}$ |  |  |  |  |  |  |
| $\mathrm{CLK}=50 \mathrm{MHz}$ | Full | IV |  | 120 | 160 | mA |
| CLK $=100 \mathrm{MHz}$ | $+25^{\circ} \mathrm{C}$ | V |  | 240 |  | mA |
| Nominal Power Dissipation |  |  |  |  |  |  |
| CLK $=50 \mathrm{MHz}$ | $+25^{\circ} \mathrm{C}$ | V |  | 600 |  | mW |
| CLK $=100 \mathrm{MHz}$ | $+25^{\circ} \mathrm{C}$ | V |  | 1.2 |  | W |
| Relative to Frequency | $+25^{\circ} \mathrm{C}$ | V |  | 11.5 |  | $\mathrm{mW} / \mathrm{MHz}$ |
| AC SPECIFICATIONS ${ }^{+}$ |  |  |  |  |  |  |
| Clock Update Rate (CLK) ${ }^{5}$ | Full | IV | 85 | 100 |  | MHz |
| Frequency Update Rate (BRCLK) ${ }^{6}$ | Full | II | 40 |  |  | MHz |
| Clock Pulse Width |  |  |  |  |  |  |
| CLK Digital " 1 " | Full | IV | 7.9 | 5.7 |  | ns |
| CLK Digital " 0 " | Full | IV | 3.8 | 2.2 |  | ns |
| Frequency Update Pulse Width |  |  |  |  |  |  |
| BRCLK Digital " 1 " | Full | II | 10 |  |  | ns |
| BRCLK Digital " 0 " | Full | II | 10 |  |  | ns |
| Input Rise/Fall Times |  |  |  |  |  |  |
| CLK Rise Time | Full | IV |  |  | 2 | ns |
| CLK Fall Time | Full | IV |  |  | 2 | ns |
| BRCLK Rise Time | Full | IV |  |  | 5 | ns |
| BRCLK Fall Time | Full | IV |  |  | 5 | ns |
| BRCLK Input Timing |  |  |  |  |  |  |
| Setup Time ( $\left.\mathrm{t}_{\mathrm{CS}}, \mathrm{t}_{\mathrm{ES}}\right)^{7}$ | Full | II | 5 |  |  | ns |
| Hold Time ( $\left.\mathrm{t}_{\mathrm{CH}}, \mathrm{t}_{\mathrm{EH}}\right)^{7}$ | Full | IV | 5 | 1.8 |  | ns |
| CLK Input Timing |  |  |  |  |  |  |
| Setup Time $\left(\mathrm{t}_{\mathrm{LS}}\right)^{8}$ | Full | IV | 2.0 | 0.7 |  | ns |
| Hold Time ( $\left.\mathrm{t}_{\text {LH }}\right)^{8}$ | Full | IV | 2.0 | 0.7 |  | ns |
| RESET 0 Timing |  |  |  |  |  |  |
| Setup Time ( $\left.\mathrm{t}_{\mathrm{RS}}\right)^{9}$ | Full | IV | 6 |  |  | ns |
| Hold Time ( $\left.\mathrm{t}_{\mathrm{RH}}\right)^{9}$ | Full | IV | 6 |  |  | ns |
| Output Timing Characteristics |  |  |  |  |  |  |
| Data Output Delay ( $\left.\mathrm{t}_{\mathrm{OD}}\right)^{10}$ | Full | IV | 3.4 | 6.1 | 8.7 |  |
| DRDY Output Delay ( $\left.\mathrm{t}_{\text {DR }}\right)^{10}$ | Full | IV | 4.7 | 7.5 | 10 | ns |
| Output Data Setup Time ( $\mathrm{t}_{\text {OS }}$ ) ${ }^{11}$ | Full | IV | 0.8 | 1.9 |  | ns |
| Carry Output Delay ${ }^{12}$ | $+25^{\circ} \mathrm{C}$ | V |  | 7.7 |  | ns |
| Spurious-Free Dynamic Range (SFDR) <br> Worst Case Spur ${ }^{13}$ | $+25^{\circ} \mathrm{C}$ | V |  | $>90$ |  | dBc |
| Latency of Initial Data ${ }^{14}$ | $+25^{\circ} \mathrm{C}$ | V |  | 14 |  | Clock Cycles |

NOTES
${ }^{1}$ Includes F[0:31], PSEL, BREN, FCLD, CIN, TGLE, BRCLK, TCMS, and RST0.
${ }^{2}$ Only the clock (CLK) is TTL compatible.
${ }^{3} f_{\text {OUT }}=1 / 2 f_{\text {CLK }}$. See performance curves.
${ }^{4}$ Nominal conditions ( $\mathrm{V}_{\mathrm{IH}}=3.4 \mathrm{~V} ; \mathrm{V}_{\mathrm{IL}}=0.4 \mathrm{~V}$ ).
${ }^{5}$ Based on minimum clock pulse width duty cycle ( $68 \% \mathrm{HIGH} @ 85 \mathrm{MHz}$ ).
${ }^{6}$ This specification defines the maximum rate at which the output frequency tuning word ( $\mathrm{F}[0: 31]$ ) can be updated.
${ }^{7}$ Referenced to 2.5 V point of rising edge of BRCLK, specified for $\mathrm{F}[0: 31]$, BREN.
${ }^{8}$ Referred to rising edge of CLK, specified for FCLD. CIN setup time is typically 1.2 ns , specified for FCLD, CIN.
${ }^{9}$ Referred to 1.6 V point of the rising edge of CLK. See Timing Diagram.
${ }^{10}$ Referenced to 1.6 V point of the rising edge of CLK for 1.6 V point of the rising/falling edge of SIN [0:11]; or the falling edge of DRDY. Load is shown below.
${ }^{11}$ Referenced from 1.6 V point of the rising/falling edge of $\operatorname{SIN}[0: 11]$ to 1.6 V point of the falling edge of DATA READY. Specified driving AD9713B; no additional capacitive load.
${ }^{12}$ Referenced from 1.6 V point of rising edge of CLK to 1.6 V point of the rising/falling edge of COUT.
${ }^{13}$ Based on proprietary phase-to-sine algorithm, TGLE HIGH.
${ }^{14}$ Referred to CLK for FCLD high. See Timing Diagram.

## EXPLANATION OF TEST LEVELS

## Test Level

I - $100 \%$ production tested.
II - $100 \%$ production tested at $+25^{\circ} \mathrm{C}$; parameter is guaranteed by design and characterization at temperature extremes.
III - Sample tested only.
IV - Parameter is guaranteed by design and characterization testing.
V - Parameter is a typical value only.
Parameters based on characterization testing have limits based on 6 sigma of a normal distribution; typical values are the mean of the distribution.

ABSOLUTE MAXIMUM RATINGS ${ }^{1}$
Supply Voltage ( $+\mathrm{V}_{\mathrm{S}}$ ) . . . . . . . . . . . . . . . . -0.5 V to +7 V Input Voltage . . . . . . . . . . . . . . . . -0.5 V to $+\mathrm{V}_{\mathrm{S}}+0.5 \mathrm{~V}$
Output Voltage Swing . . . . . . . . . . -0.5 V to $+\mathrm{V}_{\mathrm{S}}+0.5 \mathrm{~V}$
Operating Temperature Range (Ambient) $\ldots . .0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Maximum Junction Temperature ${ }^{2}$. . . . . . . . . . . . . . $+150^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (soldering, 10 seconds) . . . . . . . . . $+250^{\circ} \mathrm{C}$

## NOTES

${ }^{1}$ Absolute maximum ratings are limiting values to be applied individually, and beyond which the serviceability of the circuit may be impaired. Functional operability is not necessarily implied. Exposure to absolute maximum rating conditions for an extended period of time may affect device reliability.
${ }^{2}$ Typical thermal impedance; part soldered in place:
$\theta_{\mathrm{JA}}=62^{\circ} \mathrm{C} / \mathrm{W}$
$\theta_{\mathrm{JC}}=7^{\circ} \mathrm{C} / \mathrm{W}$.

ORDERING GUIDE

|  | Temperature <br> Radel | Package Description |
| :--- | :--- | :--- | :--- | | Package |
| :--- |
| Option |

## NOTES

${ }^{1}$ For outline information see Package Information section.
${ }^{2}$ Model AD9955KS-66 units are shipped in a standard JEDEC tray; minimum order quantity is 66 units ( 1 full tray).
${ }^{3}$ AD $9955 \mathrm{KS}-6$ units are shipped in a nonstandard tray; minimum order quantity is 6 units ( 1 full tray). Three nonstandard trays will fit in a standard JEDEC tray outline, allowing use with standard assembly equipment. Contact factory for details.
NOTE: All units are dry packed to inhibit moisture absorption. Units which are exposed to air for more than 48 hours should be baked for 24 hours at $+125^{\circ} \mathrm{C}$ prior to assembly.


AD9955 Load Circuit

## AD9955 PIN DESCRIPTIONS

| Name | Description |
| :---: | :---: |
| GND | Ground Reference Voltage Connection. |
| $+\mathrm{V}_{\text {S }}$ | Positive voltage power connection, nominally +5 V . |
| BRCLK | Buffer Register Clock. Data inputs are loaded into the Frequency Control Word Buffer Register on the rising edge of BRCLK when register is enabled (BREN input at Logic " 1 "). |
| CLK | System Clock. Continuous TTL signal for synchronizing all internal operations, except loading of Frequency Control Word Buffer Register; rising edge initiates synchronization. |
| F[0:31] | 32 parallel data inputs for loading frequency tuning word. |
| BREN | Buffer Load Enable Signal. Enables loading of data into the Frequency Control Word Buffer Register. If BREN is logic " 0 ," register retains its contents. If BREN is Logic " 1 ," theFrequency Control Word Buffer Register either (1) parallel loads the data present at $\mathrm{F}[0: 31]$ inputs (PSEL $=\mathrm{HIGH}$ ) or (2) serially shifts data present at $\mathrm{F}[31]$ input $($ PSEL $=$ LOW). |
| FCLD | Frequency Control Load Enable Signal. FCLD = HIGH enables loading of data from Frequency Control Word Buffer Register into Frequency Control Register. Loading takes place on next rising edge of CLK signal. FCLD = LOW disables loading of data. |
| DRDY | Data Ready Signal. Output data (SIN [0:11]) is valid on the rising edge of DRDY, which tracks propagation delay variations of the output data vs. temperature. The duty cycle of DRDY is dependent on the duty cycle of the CLK input. The DRDY signal should be used only for applications which have a very high clock rate ( 85 Msps ) and require operation over a wide temperature range. Normally allowed to float. |
| CIN | Carry-In signal is provided as the carry input to the least significant bit (LSB) of the 32-bit adder in the phase accumulator. This signal is used as the carry input only if the TGLE signal is a logic zero; carry has 1 LSB weight, and is used for stacking units for 64-bit DDS. Normally tied to ground. |
| TGLE | Carry Toggle Enable. When HIGH, the CIN signal is disabled, and the Carry-In toggles internally between HIGH and LOW on each clock (CLK) cycle to reduce the worst case spurious response of the digital output signal by 3.92 dB . Normally tied to ground. |
| TCMS | Twos Complement/Magnitude Mode Select. Selects binary output format of data on $\operatorname{SIN}[0: 11]$ outputs. If TCMS is a Logic " 1 ," format of output data at $\operatorname{SIN}[0: 11]$ is in twos complement format. If TCMS is a Logic " 0 ," data is binary unsigned magnitude format. Normally tied to ground. |
| SIN[0:11] | 12 parallel data bits comprising the sine data output. Frequency of the sine data outputs is defined by the |

Name Description
Frequency Control Register ( $\Delta$ phase) as

$$
f_{\text {OUT }}=f_{C L K}\left(\frac{\Delta \text { phase }}{2^{32}}\right)
$$

Binary data format of 12 -bit samples is either twos complement or unsigned magnitude, determined by TCMS signal.
RST0 Reset Phase to Zero Signal. Activates synchronous reset of the Phase Accumulation Register to a binary value of " 0 ," or zero radians. Reset is enabled when RST0 is a Logic " 1 " and takes place on rising edge of system clock (CLK). Normally low.
COUT Carry-Out signal output of the 32-bit adder in the phase accumulator; used for stacking two AD9955 units for 64-bit DDS. Normally allowed to float.
PSEL Parallel/Serial Frequency Control Word Buffer Input Selector. Selects mode for loading the Buffer Register. If a load is enabled (BREN = " 1 "), and PSEL is a Logic " 1 ," data is parallel loaded into the Frequency Control Word Buffer Register from the F0:31] inputs on the next rising edge of BRCLK. If a load is enabled and PSEL is a Logic " 0 ," data is serially shifted into the Frequency Control Word Buffer Register from the F[31] input on rising edge of BRCLK.

PIN DESIGNATIONS


## DIE INFORMATION

Die Dimensions . . . . . . . . . . . . . $215 \times 199 \times 20.7( \pm 1)$ mils
Pad Dimensions . . . . . . . . . . . . . . . . . . . . . . . . $4 \times 4$ mils Metalization . . . . . . . . . . . . . . . . . . . . . . . . . . Aluminum Backing . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . None Substrate Potential . . . . . . . . . . . . . . . . . . . . . . . . Ground Passivation . . . . . . . . . . . . . . . . . . . . . . . . . . . Oxynitride Die Attach . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . Epoxy
Bond Wire Gold


AD9955 Chip Layout


Figure 1. Block Diagram of DDS Generator

## DDS

Direct digital synthesis (DDS) is a method of deriving a wideband, digitally controlled frequency (sine wave) synthesizer from a single reference frequency (system clock).
The circuit has three major components:

1. Phase accumulator
2. Phase-to-amplitude converter
3. Digital-to-analog converter

These major stages and their relationships to one another are illustrated in the block diagram shown above.
The phase accumulator is a digital device which generates the phase increment of the output waveform. Its input is a digital word which (with the reference oscillator) determines the frequency of the output waveform. The output of the phase accumulator stage represents the current phase of the generated waveform. In effect, the accumulator serves as a variablefrequency oscillator generating a digital ramp. The frequency of
the signal is defined by $\Delta$ phase as

$$
f_{O U T}=\frac{\Delta p \text { hase }}{\Delta \text { phase }_{\text {MAX }}} f_{\text {CLOCK }}=\frac{\Delta \text { phase }}{2^{N}} f_{C L O C K}
$$

Translating phase information from the phase accumulator into amplitude data takes place in the phase-to-amplitude converter. This is most commonly accomplished by means of a look-up table (LUT) stored in memory, but may be calculated instead using a digital algorithm to minimize circuit complexity and/or increase the update rate.

In the final step of frequency synthesis, amplitude data is con* verted into an analog signal. This is done by a digital-to-analog (D/A) converter which must have good linearity; low glitch impulse; and fast, symmetrical rise and fall times. When it does, the frequency synthesizer is able to produce a spectrally pure waveform.


Figure 2. Reset Timing

## AD9955 DIRECT DIGITAL SYNTHESIZER

The AD9955 is a digital device which integrates a 32 -bit phase accumulator and 15 -bit phase to 12 -bit sine amplitude converter (see block diagram). The circuit is fabricated in a CMOS process technology, and designed to minimize the number of external devices necessary to implement a high speed DDS system.

## Phase Accumulator Architecture

The phase accumulator is comprised of 8 pipelined, 4-bit adder cells to achieve the typical 100 MHz operation. The pipelined accumulator requires the use of input data alignment registers between the frequency control register and the accumulator to maintain the phase-coherent switching characteristics of the DDS. The alignment registers on the 16 least significant bits of the accumulator were eliminated to save power and reduce the number of pipeline delays; this results in a maximum phase discontinuity of $0.005^{\circ}$.


Figure 3. Power Supply Current vs. Output Frequency

The accumulator incorporates carry input and output pins (CIN and COUT) to enable stacking of devices to achieve greater than 32-bit resolution. In normal operation, CIN will be connected to ground, and COUT allowed to float.
An additional feature of the AD9955 accumulator is controlled by the TGLE pin. With this pin tied HIGH, the CIN pin is disabled and the carry input is internally toggled on successive clock cycles. The toggling of the carry input has two major benefits. The theoretical worst case spur is reduced by 3.92 dB , making the worst case spurious free dynamic range of the SIN[0:11] outputs 90.3 dBc . In addition, the DDS spur performance is made more consistent versus frequency due to the randomizing of the errors introduced by possible DAC nonlinearities.

## Resetting the AD9955

The synchronous reset function (RST0) resets the output of the phase accumulator to zero radians, allowing the user to initialize the AD9955 from a known state. A reminder: the RSTO signal does not affect the contents of the alignment registers on either side of the adders. To properly reset the AD9955 to zero radians (SIN[0:11] $=100000000000$ ), perform the following steps in the order listed:

1. Frequency input should be preloaded to zero $(\mathrm{F}[0: 31]=0$; see loading the AD9955).
2. Four clock cycles must pass to clear the prealignment registers.
3. The RSTO signal should go HIGH for at least 12 ns , and meet required setup ( $\mathrm{t}_{\mathrm{RS}}$ ) and hold ( $\mathrm{t}_{\mathrm{RH}}$ ) times.
4. Nine additional clock cycles must pass to clear the postalignment registers and allow the new tuning word ( 0 radians) to propagate through the phase to sine amplitude conversion circuitry.
Critical timing and pipeline delays required for resetting the AD9955 are illustrated in the reset timing diagram. After the RSTO signal is returned to LOW, a new frequency can be


Figure 4. Parallel Mode Timing
loaded into the frequency control register; the $\operatorname{SIN}[0: 11]$ outputs will remain at the midscale value for 14 clock cycles while the new tuning word propagates through the AD9955.

## Loading the Frequency Control Word

For convenience, the frequency control register is double buffered at the inputs to allow asynchronous loading of a new frequency control word. The frequency control word buffer register can be loaded in either parallel (PSEL $=\mathrm{HIGH}$ ) or serial (PSEL = LOW) mode. The data is clocked on the rising edge of the BRCLK signal when the BREN pin is held HIGH. In serial mode, the data is fed through the LSB ( $\mathrm{F}[31]$ ) and requires multiple clock edges to shift in data.
Once new frequency data is loaded into the frequency control word buffer, it is passed into the frequency control register on the next rising edge of the CLK signal following a HIGH signal on the FCLD pin. The new frequency control word is then used as the input to the phase accumulator and it begins to accumulate at the new rate. The Parallel Mode Timing diagram illustrates the critical timing relationships for loading new frequency data into the AD9955 from the reset condition; these relationships remain the same for any arbitrary condition.

## Phase to Sine Architecture

The phase to sine amplitude converter calculates the sine amplitude using a proprietary algorithm for the first $90^{\circ}$ of the sine cycle, and takes advantage of the symmetry of the waveform to calculate the remaining quadrants. Only the 15 most significant bits of the phase accumulator output are needed to achieve the 12-bit accuracy of the SIN[0:11] outputs.
In normal operation (TGLE $=$ LOW), the frequency tuning word may take on both odd and even values. Odd frequency input words will result in a spurious free dynamic range (SFDR) of 90.3 dBc , while even frequency words may have spurious frequency content as high as 86.4 dBc . The carry toggle feature discussed above guarantees a worst case SFDR of the frequency tuning words of 90.3 dBc .

The architecture and implementation of the phase to sine algorithm uses several compression techniques to reduce the amount of internal memory required, and to guarantee a minimum throughput rate of 85 MHz , a new benchmark for CMOS DDS circuits. Accordingly, the CLK input is TTL logic compatible, and buffered internally to minimize input capacitance. Although most devices will operate with a $50 \%$ duty cycle on CLK input, guaranteed operation at 85 MHz will require adjustment of clock duty cycle (see specification table). All other inputs and outputs are CMOS logic compatible.

## SIN Outputs

The SIN[0:11] outputs of the phase to sine conversion circuitry are latched at the output to minimize data skew. The TCMS control signal specifies the format of the output data as either binary unsigned magnitude or two's complement format. The output data is valid on the rising edge of the data ready signal (DRDY), and is designed to track the temperature variation of the output data. The DRDY signal is not recommended for clocking the DAC because of phase uncertainty (jitter). The parallel mode timing diagram also illustrates the timing relationships relevant to capturing the output data, and also the pipeline delays associated with loading a new frequency word. The curves below show the typical propagation delays of $\operatorname{SIN}[0: 11]$ and DRDY vs. temperature.

## SERIAL MODE OPERATION

Serial data is shifted into Pin F31 on the rising edge of the BRCLK. The setup and hold times shown in Figure 4 (Parallel Mode Timing) apply to loading serial data as well. Thirty-two cycles of the BRCLK are needed to shift the entire frequency control word into the Frequency Control Word Buffer Register. Bits are clocked in ascending order, F[31], F[30], F[29] . . . with the MSB clocked in last. A HIGH signal on the FCLD pin allows all 32 bits to pass to the Frequency Control Register on the next rising edge of the CLK.


Figure 5. Data Ready Delay vs. Ambient Temperature


Figure 6. Output Delay vs. Ambient Temperature

## Applications Information

The AD9955 can be used in digital demodulation applications to provide a digital frequency reference, or combined with a DAC to provide an analog frequency reference. In the latter application, a DAC with exceptional ac performance is required. The diagram below gives a recommended hookup for a complete direct digital synthesizer employing the AD9955 and the AD9721, a 10-bit 100 Msps DAC.
As in all high speed applications, proper layout is critical; it is particularly important when both analog and digital signals are involved. Analog signal paths should be kept as short as possible, and properly terminated to avoid reflections.

Digital signal paths should also be kept short, and run lengths matched to avoid propagation delay mismatch. In the diagram, series resistors ( 130 ohms ) are inserted in the connections between the SIN[0:9] outputs of the AD9955 and the data inputs of the AD9721 ( $\mathrm{D}_{1}-\mathrm{D}_{10}$ ) to reduce data feedthrough effects and to insure that the setup and hold times of the AD9721's input register are met over the commercial temperature range $\left(0^{\circ} \mathrm{C}\right.$ to $\left.+70^{\circ} \mathrm{C}\right)$.
Layout of the ground circuit is a critical factor. A single, low impedance ground plane will reduce noise on the circuit ground. Power supplies should be capacitively coupled to the ground plane to reduce noise in the circuit. Multilayer boards allow designers to lay out signal traces without interrupting the ground plane, and provide low impedance power planes.

## Evaluation Board

An evaluation board is available which combines the AD9955 and either the AD 9713 B , an 80 Msps 12 -bit DAC, or the AD9721, a 10 - bit 100 Msps DAC, both of which are supplied with the board. This simplifies the task of evaluating and characterizing the DDS synthesizer. The block diagram shown in Figure 9 illustrates its operation. For more information, please consult the AD9955/PCB data sheet.


Figure 7. AD9955/AD9721 DDS Synthesizer


Figure 8. AD9955 Output Spectrum


Figure 9. AD9955 DDS Evaluation Board Setup

Table I. Recommended Operation

| Parameter | Input Voltage |  |  |
| :--- | :--- | :--- | :--- |
|  | Min | Nominal | Max |
| +V $_{\text {S }}$ | 4.75 | 5.0 | 5.25 |
| CLK | 0 | TTL | $+V_{S}$ |
| BRCLK, PSEL, BREN, | 0 | CMOS | $+V_{S}$ |
| FCLD, CIN, TGLE, |  |  |  |
| TCMS, RSTO, F[0:31] |  |  |  |

AD9955/AD9721 20 MSPS 2.10 MHz 10dB/


Figure 10. AD9955/AD9721 Output Spectrum


START 200 kHz
STOP 10.000 MHz
Figure 11. AD9955/AD9721 Output Spectrum

Figure 12. AD9955/AD9721 Output Spectrum


START 200 kHz
STOP 25.00 MHz
Figure 13. AD9955/AD9721 Output Spectrum


CENTER 12.500 MHz
SPAN 2.50 MHz
Figure 14. AD9955/AD9721 Output Spectrum


Figure 15. AD9955/AD9721 Output Spectrum


Figure 16. AD9955/AD9721 Output Spectrum


CENTER 20.00 MHz
SPAN 2.50 MHZ
Figure 17. AD9955/AD9721 Output Spectrum


Figure 18. AD9955/AD9721 Output Spectrum


Figure 19. AD9955/AD9721 Output Spectrum


Figure 20. AD9955/AD9721 Output Spectrum


Figure 21. AD9955/AD9721 Output Spectrum

## GENERAL DESCRIPTION

Analog Devices offers a broad line of modular ac/dc power supplies that provide both OEMs and designers a reliable, easy to use, low-cost solution to their power requirements. Models are available in PC mountable and chassis mountable designs with 5 volt to 15 volt (single, dual, triple) outputs and current ratings from 100 mA to 5 amps . Since these modular supplies are fully encapsulated, no trimming or external component selection is necessary; simply mount the unit, connect power and output leads, and you're on the air! Most Analog Devices' power supplies are available from stock in both large and small quantities with substantial discounts being applied to large quantity orders.

## AC/DC POWER SUPPLY FEATURES

- Current Limit Short Circuit Protection
- PC Mounted and Chassis Mounted Versions
- Single ( +5 V ), Dual ( $\pm 15 \mathrm{~V}$ ), and Triple ( $\pm 15 \mathrm{~V} /+5 \mathrm{~V}$ ) Output Supplies
- Current Outputs:

100 mA to 500 mA for Dual and Triple Output Supplies
1000 mA to 5000 mA for Single Output Supplies

- Wide Input Voltage Range
- Low Output Ripple and Noise
- Excellent Line \& Load Regulation Characteristics
- High Temperature Stability
- Free-Air Convection Cooling; No External Heat Sink Required


## GENERAL SPECIFICATIONS

Power Requirements

| Input Voltage Range: | 105 V ac to 125 V ac |
| :--- | :--- |
| Frequency: | 50 Hz to 250 Hz |

Electrical Specifications
Temperature Coefficient: $\quad 0.02 \% /{ }^{\circ} \mathrm{C}$
Output Voltage Accuracy: $\pm 2 \%$, max
See Specifications Table
500 V rms, min
$50 \mathrm{M} \Omega$
All ac/dc power supplies employ current limiting. They can withstand substantial overload including direct short. Prolonged operation should be avoided since excessive temperature rises will occur.
Environmental Requirements
Operating Temperature
Range: $\quad-25^{\circ} \mathrm{C}$ to $+71^{\circ} \mathrm{C}$
Storage Temperature
Range: $\quad-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$

SPECIFICATIONS - Typical @ $+25^{\circ} \mathrm{C}$ and 115 V ac 60 Hz unless otherwise noted ${ }^{\star}$
$\left.\begin{array}{lllllllll} & \text { Type } & \text { Model } & \begin{array}{l}\text { Output } \\ \text { Voltage } \\ \text { Volts }\end{array} & \begin{array}{l}\text { Output } \\ \text { Current } \\ \text { mA }\end{array} & \begin{array}{l}\text { Line Reg. } \\ \text { max } \\ \%\end{array} & \begin{array}{l}\text { Load Reg. } \\ \text { max } \\ \%\end{array} & \begin{array}{l}\text { Output } \\ \text { Voltage } \\ \text { Error max }\end{array} & \begin{array}{l}\text { Ripple \& } \\ \text { Noise } \\ \text { mV rms max }\end{array}\end{array} \begin{array}{l}\text { Dimensions } \\ \text { Inches }\end{array}\right]$

[^274]
# Power Supplies <br> Modular DC/DC Converters 

## GENERAL DESCRIPTION

Analog Devices' line of compact dc/dc converters offers system designers a means of supplying a reliable, easy to use, low cost solution to a variety of floating (analog and digital) power applications. These devices provide high accuracy, short circuit protected, regulated outputs with very low output noise and ripple characteristics.

Nine models are offered in four power levels of 1 watt, 1.8 watts, 4.5 watts and 6 watts. Input voltage versions include 5 volt, 12 volt and 28 volt with output ranges as follows:
+5 volt, $\pm 12$ volts and $\pm 15$ volts at $\pm 40 \mathrm{~mA}$ to 1000 mA output current capability.
Most models are high efficiency (typically over 60\% at full load) and feature complete 6 -sided continuous shielding for EMI/RFI protection. A $\pi$-type input filter is contained, in some models, which virtually eliminates the effects of reflected input ripple current. Most Analog Devices' dc/dc converters are available from stock in both large and small quantities with substantial discounts being applied to large quantity orders.

## DC/DC POWER SUPPLY FEATURES

- Inaudible ( $>20 \mathrm{kHz}$ ) Converter Switching Frequency
- Continuous, Six-Sided EMI/RFI Shielding Except on 1 Watt and 1.8 Watt Models
- Output Short Circuit Protection (Either Output to Common)
- Automatic Restart After Short Condition Removed
- Automatic Starting with Reverse Current Injected into Outputs
- Low Output Ripple and Noise
- High Temperature Stability
- Free Air Convection Cooling

No external heat sink or specification derating is required over the operating temperature range.

## GENERAL SPECIFICATIONS FOR 1 W AND 1.8 W MODELS

Line Regulation - Full Range: $\pm 0.3 \%$ ( $\pm 1 \%$ max, 949)
Load Regulation - No Load to Full Load: $\pm 0.4 \%$ ( $\pm 0.5 \%$ max, 949 )
Output Noise and Ripple: 20 mV p-p, with $15 \mu \mathrm{~F}$ tantalum capacitor across each output ( 2 mV rms max, 949)
Breakdown Voltage: 300 V dc $\min (500 \mathrm{~V}$ dc min, 949)
Input Filter Type: $\pi$
Operating Temperature Range: $-25^{\circ} \mathrm{C}$ to $+71^{\circ} \mathrm{C}$
Storage Temperature Range: $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ $\left(+100^{\circ} \mathrm{C}, 949\right)$
Fusing: If input fusing is desired, we recommend the use of a slow blow type fuse that is rated at $150 \%-200 \%$ of the $\mathrm{dc} / \mathrm{dc}$ converter's full load input current.

## GENERAL SPECIFICATIONS FOR 4.5 W AND 6 W MODELS

Line Regulation - Full Range: $\pm 0.07 \% \max ( \pm 0.02 \% \max$, 960 Series) ( $\pm 0.1 \%$ max, 943)
Load Regulation - No Load to Full Load: $\pm 0.07 \%$ max ( $\pm 0.02 \%$ max, 960 Series) $( \pm 0.1 \%$ max, 943 )
Output Noise and Ripple: 1 mV rms max
Breakdown Voltage: 500 V dc min
Input Filter Type: $\pi$
Operating Temperature Range: $-25^{\circ} \mathrm{C}$ to $+71^{\circ} \mathrm{C}$
Storage Temperature Range: $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Fusing: If input fusing is desired, we recommend the use of a slow blow type fuse that is rated at $150 \%-200 \%$ of the dc/dc converter's full load input current.

SPECIFICATIONS - Typical @ $+25^{\circ} \mathrm{C}$ at nominal input voltage unless otherwise noted ${ }^{\star}$

| Model | Output <br> Voltage <br> Volts | Output Current mA | Input <br> Voltage <br> Volts | Input ${ }^{1}$ <br> Voltage <br> Range <br> Volts | Input <br> Current Full Load | Output <br> Voltage <br> Error max | Temperature Coefficient $1^{\circ} \mathrm{C}$ max | Efficiency <br> Full Load min | Dimensions Inches |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 943 | 5 | 1000 | 5 | 4.75/5.25 | 1.52 A | $\pm 1 \%$ | $\pm 0.02 \%$ | 62\% | $2.0 \times 2.0 \times 0.38$ |
| 958 | 5 | 100 | 5 | 4.5/5.5 | 200 mA | $\pm 5 \%$ | $\pm 0.01 \%$ (typ) | 50\% | $1.25 \times 0.8 \times 0.4$ |
| 941 | $\pm 12$ | $\pm 150$ | 5 | 4.75/5.25 | 1.17 A | $\pm 1 \%$ | $\pm 0.01 \%$ | 58\% | $2.0 \times 2.0 \times 0.38$ |
| 960 | $\pm 12$ | $\pm 40$ | 5 | 4.5/5.5 | 384 mA | $\pm 5 \%$ | $\pm 0.01 \%$ (typ) | 50\% | $1.25 \times 0.8 \times 0.4$ |
| 962 | $\pm 15$ | $\pm 33$ | 5 | 4.5/5.5 | 396 mA | $\pm 5 \%$ | $\pm 0.01 \%$ (typ) | 50\% | $1.25 \times 0.8 \times 0.4$ |
| 966 | $\pm 15$ | $\pm 190$ | 12 | 11.2/13.2 | 710 mA | $\pm 1 \%$ | $\pm 0.005 \%$ (typ) | 62\% (typ) | $2.0 \times 2.0 \times 0.38$ |
| 949 | $\pm 15$ | $\pm 60$ ** | 5 | 4.65/5.5 | 0.6 A | $\pm 2 \%$ | $\pm 0.03 \%$ | 58\% | $2.0 \times 1.0 \times 0.375$ |
| 940 | $\pm 15$ | $\pm 150$ | 5 | 4.75/5.25 | 1.35 A | $\pm 1 \%$ | $\pm 0.01 \%$ | 62\% | $2.0 \times 2.0 \times 0.38$ |
| 945 | $\pm 15$ | $\pm 150$ | 28 | 23/31 | $\cdot 250 \mathrm{~mA}$ | $\pm 0.5 \%$ | $\pm 0.01 \%$ | 61\% | $2.0 \times 2.0 \times 0.38$ |

NOTES
${ }^{1}$ Models 940 and 941 will deliver up to 120 mA output current (and Model 943 will deliver up to 600 mA ) over an input voltage range of 4.65 V dc and 5.5 V dc.
*Consult Analog Devices Power Supplies Catalog for additional information.
$\star \star$ Single-ended or unbalanced operation is permissible such that total output current load does not exceed a total of 120 mA .
Specifications subject to change without notice.

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[^275]| ADI Letter | PMI Letter | Package | MIL-M38510 |  |
| :---: | :---: | :---: | :---: | :---: |
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Shrink Small Outline Package (SSOP)

## Package Description

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16-Lead 23-14
16-Lead 23-14
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40-Lead 23-14
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## Package Information－Outline Dimensions

## Side Brazed DIP（Ceramic）

| ADI Letter <br> Designator | PMI Letter <br> Designator | Product Description | $\mathbf{a}^{\star}$ |  | $\mathbf{b}^{\star}$ |  | $\mathrm{c}^{\star}$ |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max | Min | Max | Min | Max |
| D－8 |  | 8－Lead | 0.512 （13．005） | 0.528 （14．41） | 0.280 （7．11） | 0.320 （8．13） |  | 0.210 （5．33） |
| D－14 | YB＊＊ | 14－Lead |  | 0.785 （19．94） | 0.290 （7．37） | 0.320 （8．13） |  | 0.200 （5．08） |
| D－16 | QB＊＊ | 16－Lead |  | 0.840 （21．34） | 0.290 （7．37） | 0.320 （8．13） |  | 0.200 （5．08） |
| D－18 | XB＊＊ | 18－Lead |  | 0.960 （23．38） | 0.290 （7．37） | 0.320 （8．13） |  | 0.200 （5．08） |
| D－20 |  | 22－Lead |  | 1.060 （26．92） | 0.290 （7．37） | 0.320 （8．13） |  | 0.200 （5．08） |
| D－22 | RB＊＊ | 20－Lead |  | 1.111 （28．22） | 0.290 （7．37） | 0.320 （8．13） |  | 0.200 （5．08） |
| D－24 | VB＊＊ | 24－Lead |  | 1.290 （32．77） | 0.590 （14．99） | 0.620 （15．75） |  | 0.225 （5．72） |
| D－24A |  | 24－Lead（Single Width） |  | 1.280 （32．51） | 0.290 （7．37） | 0.320 （8．13） |  | 0.200 （5．08） |
| D－28 | TB＊＊ | 28－Lead |  | 1.490 （37．85） | 0.590 （14．99） | 0.620 （15．75） |  | 0.225 （5．72） |
| D－28A |  | 28－Lead（Single Width） |  | 1.480 （37．59） | 0.290 （7．37） | 0.320 （8．13） |  | 0.200 （5．08） |
| D－40 |  | 40－Lead |  | 2.096 （53．24） | 0.521 （13．23） | 0.630 （16．00） |  | 0.225 （5．72） |
| D－48 |  | 48－Lead | 2.376 （60．35） | 2.424 （63．57） | 0.520 （13．21） | 0.630 （16．00） |  | 0.225 （5．72） |

＊For complete package dimensions see reference manual or data sheet
＊＊Special order only
$\mathbf{a}^{\star} \mathbf{b}^{\star}$

Side Brazed DIP for Hybrids（Ceramic）


| ADI Letter | PMI Letter | Product | $\mathbf{a}^{\star}$ |  | b＊ |  | ${ }^{\star}{ }^{\text {® }}$ |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Designator | Designator | Description | Min | Max | Min | Max | Min | Max |
| DH－24A |  | 24－Lead |  | 1.212 （30．79） | 0.590 （14．99） | 0.620 （15．75） |  | 0.225 （5．72） |
| DH－28 |  | 28－Lead |  | 1.414 （35．92） | 0.590 （14．99） | 0.610 （15．49） |  | 0.225 （5．72） |

＊For complete package dimensions see reference manual or data sheet．


## Package Information-Outline Dimensions

## Bottom Brazed DIP (Ceramic)

| ADI Letter Designator | PMI Letter Designator | Product Description | $\mathbf{a}^{\star}$ |  | $\mathbf{b}^{\star}$ |  | $c^{\star}$ |  | $\mathrm{d}^{\star}$ |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max | Min | Max | Min | Max | Min | Max |
| DH-40A |  | 40-Lead | 2.074 (52.68) | 2.116 (53.75) | 0.89 (22.61) | 0.91 (23.11) |  | 0.225 (5.72) | 1.08 (27.41) | 1.10 (27.97) |
| DH-48A |  | 48-Lead | 2.450 (62.23) | 2.500 (63.50) | 0.990 (25.15) | 1.010 (25.65) | 0.177 (4.50) | 0.233 (5.92) | 1.287 (32.69) | 1.313 (33.35) |

*For complete package dimensions see reference manual or data sheet.

## Leadless Chip Carrier (Ceramic)



| ADI Letter <br> Designator | PMI Letter <br> Designator | Product Description | $\mathbf{a}^{\star}$ |  | $\mathrm{b}^{\star}$ |  | $c^{\star}$ |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max | Min | Max | Min | Max |
| E-20A | RC | 20-Terminal | 0.342 (8.69) | 0.358 (9.09) | 0.342 (8.69) | 0.358 (9.09) | 0.064 (1.63) | 0.100 (2.54) |
| E-28A | TC | 28-Terminal | 0.442 (11.23) | 0.458 (11.63) | 0.442 (11.23) | 0.458 (11.63) | 0.064 (1.63) | 0.100 (2.54) |
| E-44A |  | 44-Terminal | 0.640 (16.26) | 0.662 (16.82) | 0.640 (16.26) | 0.662 (16.82) | 0.064 (1.63) | 0.100 (2.54) |
| E-68A |  | 68-Terminal | 0.940 (23.88) | 0.965 (24.51) | 0.940 (23.88) | 0.965 (24.51) | 0.065 (1.65) | 0.103 (2.62) |

*For complete package dimensions see reference manual or data sheet.


## Flatpack (Ceramic)

| ADI Letter | PMI Letter | Product | $\mathbf{a}^{\star}$ |  |  | $\mathbf{b}^{\star}$ |  | $\mathrm{c}^{\star}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Designator | Designator | Description | Min | Max | Min | Max | Min | Max |
| F-2A |  | 2-Lead |  | 0.250 (6.35) | 0.081 (2.06) | 0.093 (2.36) | 0.044 (1.12) | 0.066 (1.68) |

*For complete package dimensions see reference manual or data sheet.

*For complete package dimensions see reference manual or data sheet.
Pin Grid Array (Plastic)

| ADI Letter Designator | PMI Letter <br> Designator | Product <br> Description | $\mathbf{a}^{\star}$ |  | $\mathbf{b}^{\star}$ |  | c* |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max | Min | Max | Min | Max |
| 223-PPGA |  | 223-Lead | 1.856 (47.14) | 1.864 (47.35) | 1.856 (47.14) | 1.864 (47.35) | 0.130 (3.30) | 0.166 (4.22) |

[^276]
## Package Information-Outline Dimensions

2-LEAD


8-LEAD


3-LEAD


10-LEAD


6-LEAD


12-LEAD


## Metal Can

| ADI Letter <br> Designator | PMI Letter <br> Designator | Product Description | $\mathbf{a}^{\star}$ |  | b* |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max | Min | Max |
| H-02A |  | 2-Lead | 0.209 (5.31) | 0.230 (5.84) | 1.125 (3.17) | 0.150 (3.81) |
| H-03A |  | 3-Lead (TO-52) | 0.209 (5.31) | 0.230 (5.84) | 0.115 (2.92) | 0.150 (3.81) |
| H-03B |  | 3-Lead (TO-5 Style) | 0.335 (8.51) | 0.370 (9.40) | 0.165 (4.19) | 0.185 (4.70) |
|  | H | 6-Lead (TO-78) | 0.335 (8.51) | 0.370 (9.40) | 0.175 (4.45) | 0.230 (5.84) |
| H-08A | J | 8-Lead (TO-99) | 0.335 (8.51) | 0.370 (9.40) | 0.175 (4.45) | 0.230 (5.84) |
| H-10A | K | 10-Lead (TO-100) | 0.335 (8.51) | 0.370 (9.40) | 0.175 (4.45) | 0.230 (5.84) |
| H-12A |  | 12-Lead (TO-8 Style) | 0.592 (15.04) | 0.615 (15.62) | 0.148 (3.76) | 0.226 (5.74) |

*For complete package dimensions see reference manual or data sheet.

## Plastic



| ADI Letter <br> Designator | PMI Letter <br> Designator | Product Description | $\mathbf{a}^{\star}$ |  | $\mathbf{b}^{\star}$ |  | c* |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max | Min | Max | Min | Max |
| TO-92 |  | 3-Lead | 0.170 (4.32) | 0.210 (5.33) | 0.175 (4.45) | 0.205 (5.21) | 0.125 (3.18) | 0.165 (4.19) |

*For complete package dimensions see reference manual or data sheet.


## J-Leaded Chip Carrier

| ADI Letter Designator | PMI Letter <br> Designator | Product <br> Description | $\mathbf{a}^{\star}$ |  | $\mathrm{b}^{\star}$ |  | c* |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max | Min | Max | Min | Max |
| J-28 |  | 28-Lead | 0.498 (12.65) | 0.491 (12.47) | 0.489 (12.42) | 0.491 (12.47) |  | 0.125 (3.18) |
| J-44 |  | 44-Lead | 0.680 (17.27) | 0.700 (17.78) | 0.680 (17.27) | 0.700 (17.78) | 0.100 (2.54) | 0.135 (3.43) |
| J-68 |  | 68-Lead | 0.980 (24.89) | 1.000 (25.4) | 0.980 (24.89) | 1.000 (25.4) | 0.100 (2.54) | 0.135 (3.43) |

*For complete package dimensions see reference manual or data sheet.


## Metal Platform (DIP)

| II Letter | PMI Letter | Product |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Designator | Designator | Description | Min | Max | Min | Max | Min | Max |
| M-40 |  | 40-Lead |  | 2.145 (54.483) |  | 1.145 (29.083) |  | 0.19 (4.83) |
| M-46 |  | 46-Lead |  | 2.380 (60.45) |  | 1.580 (40.13) |  | 0.231 (5.87) |

*For complete package dimensions see reference manual or data sheet.

## Package Information-Outline Dimensions

| Plastic |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ADI Letter | PMI Letter | Product |  |  |  |  |  |  |
| Designator | Designator | Description | Min | Max | Min | Max | Min | Max |
| $\mathrm{N}-8$ | P | 8-Lead | 0.348 (8.84) | 0.430 (10.92) | 0.300 (7.62) | 0.325 (8.26) |  | 0.210 (5.33) |
| N-14 | P | 14-Lead | 0.725 (18.42) | 0.795 (20.19) | 0.300 (7.62) | 0.325 (8.26) |  | 0.210 (5.33) |
| N-16 | P | 16-Lead | 0.745 (18.92) | 0.840 (21.34) | 0.300 (7.62) | 0.325 (8.26) |  | 0.210 (5.33) |
| N-18 | P | 18-Lead | 0.845 (21.46) | 0.925 (23.49) | 0.300 (7.62) | 0.325 (8.26) |  | 0.210 (5.33) |
| N-20 | P | 20-Lead | 0.925 (23.50) | 1.060 (26.90) | 0.300 (7.62) | 0.325 (8.26) |  | 0.210 (5.33) |
| N-22 | P | 22-Lead | 1.020 (25.91) | 1.080 (27.43) | 0.300 (7.62) | 0.325 (8.26) |  | 0.210 (5.33) |
| N-24 | P | 24-Lead | 1.125 (28.58) | 1.275 (32.39) | 0.300 (7.62) | 0.325 (8.26) |  | 0.210 (5.33) |
| N-24A | P | 24-Lead (Double Width) | 1.150 (29.21) | 1.290 (32.77) | 0.600 (15.24) | 0.625 (15.88) |  | 0.250 (6.35) |
| N-24B |  | 24-Lead | 1.185 (30.10) | 1.205 (30.60) | 0.330 (8.40) | 0.346 (8.80) | 0.142 (3.60) | 0.162 (4.10) |
| $\mathrm{N}-28$ | P | 28-Lead | 1.380 (35.10) | 1.565 (39.75) | 0.600 (15.24) | 0.625 (15.88) |  | 0.250 (6.35) |
| N-28A | P | 28-Lead | 1.440 (36.58) | 1.450 (36.83) | 0.594 (15.09) | 0.606 (15.39) |  | 0.200 (5.08) |
| N-40A | P | 40-Lead |  | 2.080 (52.83) | 0.580 (14.73) | 0.620 (15.75) |  | 0.200 (5.08) |
| N-48 | P | 48-Lead | 2.385(60.58) | 2.480 (62.99) | 0.590 (14.99) | 0.630 (16.0) |  | 0.250 (6.35) |

${ }^{\star}$ For complete package dimensions see reference manual or data sheet.

## Plastic Leaded Chip Carrier (PLCC)

| ADI Letter Designator | PMI Letter <br> Designator | Product Description | $\mathbf{a}^{\star}$ |  | $\mathrm{b}^{\star}$ |  | $c^{\star}$ |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max | Min | Max | Min | Max |
| P-20A | PC | 20-Lead | 0.385 (9.78) | 0.395 (10.03) | 0.385 (9.78) | 0.395 (10.03) | 0.165 (4.19) | 0.180 (4.57) |
| P-28A | PC | 28-Lead | 0.485 (12.32) | 0.495 (12.57) | 0.485 (12.32) | 0.495 (12.57) | 0.165 (4.19) | 0.180 (4.57) |
| P-44A |  | 44-Lead | 0.685 (17.40) | 0.695 (17.65) | 0.685 (17.40) | 0.695 (17.65) | 0.165 (4.19) | 0.180 (4.57) |
| P-68A |  | 68-Lead | 0.885 (22.48) | 0.995 (25.27) | 0.885 (22.48) | 0.995 (25.27) | 0.169 (4.29) | 0.175 (4.45) |

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## Plastic Quad Flatpack



| ADI Letter <br> Designator | PMI Letter Designator | Product <br> Description | $\mathbf{a}^{\star}$ |  | $\mathrm{b}^{\star}$ |  | ${ }^{\text {* }}$ |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max | Min | Max | Min | Max |
| P-100 |  | 100-Lead | 0.897 (22.78) | 0.903 (22.94) | 0.897 (22.78) | 0.903 (22.94) | 0.160 (4.06) | 0.180 (4.57) |

*For complete package dimensions see reference manual or data sheet.


## Cerdip

| ADI Letter <br> Designator | PMI Letter <br> Designator | Product <br> Description | $\mathbf{a}^{\star}$ |  |  | $\mathrm{b}^{\star}$ |  | * |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max | Min | Max | Min | Max |
| Q-8 | Z | 8-Lead |  | 0.405 (10.29) | 0.290 (7.37) | 0.320 (8.13) |  | 0.200 (5.08) |
| Q-14 | Y | 14-Lead |  | 0.785 (19.94) | 0.290 (7.37) | 0.320 (8.13) |  | 0.200 (5.08) |
| Q-16 | Q | 16-Lead |  | 0.840 (21.34) | 0.290 (7.37) | 0.320 (8.13) |  | 0.200 (5.08) |
| Q-18 | X | 18-Lead |  | 0.960 (24.38) | 0.290 (7.37) | 0.320 (8.13) |  | 0.200 (5.08) |
| Q-20 | R | 20-Lead |  | 1.060 (26.92) | 0.290 (7.37) | 0.320 (8.13) |  | 0.200 (5.08) |
| Q-22 |  | 22-Lead |  | 1.175 (29.85) | 0.390 (9.09) | 0.420 (10.67) |  | 0.200 (5.08) |
| Q-24 | W | 24-Lead |  | 1.280 (32.51) | 0.290 (7.37) | 0.320 (8.13) |  | 0.200 (5.08) |
| Q-24A |  | 24-Lead (Wide Body) |  | 1.280 (32.51) | 0.590 (15.00) | 0.620 (15.75) |  | 0.200 (5.08) |
| Q-28 | T | 28-Lead |  | 1.490 (37.85) | 0.590 (14.99) | 0.620 (15.75) |  | 0.225 (5.72) |

*For complete package dimensions see reference manual or data sheet.

## Package Information-Outline Dimensions



Small Outline (SO)

| ADI Letter <br> Designator | PMI Letter <br> Designator | Product <br> Description | $\mathbf{a}^{\star}$ |  | $\mathbf{b}^{\star}$ |  | c* |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max | Min | Max | Min | Max |
| R-8 |  | 8-Lead | 0.1890 (4.80) | 0.1968 (5.00) | 0.1497 (3.80) | 0.1574 (4.00) | 0.094 (2.39) | 0.102 (2.59) |
|  | SO-8 | 8-Lead | 0.1890 (4.80) | 0.1968 (5.00) | 0.1497 (3.80) | 0.1574 (4.00) | 0.0532 (1.35) | 0.0688 (1.75) |
| R-14 | SO-14 | 14-Lead | 0.3367 (8.55) | 0.3444 (8.75) | 0.1497 (3.80) | 0.1574 (4.00) | 0.0532 (1.35) | 0.0688 (1.75) |
| R-16A | SO-16 | 16-Lead | 0.3859 (9.80) | 0.3937 (10.00) | 0.1497 (3.80) | 0.1574 (4.00) | 0.0532 (1.35) | 0.0688 (1.75) |
| R-16 | SOL-16 | 16-Lead (Wide Body) | 0.3977 (10.10) | 0.4133 (10.50) | 0.2914 (7.40) | 0.2992 (7.60) | 0.0926 (2.35) | 0.1043 (2.65) |
| R-18 | SOL-18 | 18-Lead | 0.4469 (11.35) | 0.4625 (11.75) | 0.2914 (7.40) | 0.2992 (7.60) | 0.0926 (2.35) | 0.1043 (2.65) |
| R-20 | SOL-20 | 20-Lead | 0.4961 (12.60) | 0.5118 (13.00) | 0.2914 (7.40) | 0.2992 (7.60) | 0.0926 (2.35) | 0.1043 (2.65) |
| R-24 | SOL-24 | 24-Lead | 0.5985 (15.20) | 0.6141 (15.60) | 0.2914 (7.40) | 0.2992 (7.60) | 0.0926 (2.35) | 0.1043 (2.65) |
| R-24A |  | 24-Lead | 0.586 (14.88) | 0.606 (15.39) | 0.205 (5.21) | 0.221 (5.61) | 0.067 (1.70) | 0.089 (2.25) |
| R-28 | SOL-28 | 28-Lead | 0.6969 (17.70) | 0.7125 (18.10) | 0.2914 (7.40) | 0.2992 (7.60) | 0.0926 (2.35) | 0.1043 (2.65) |

*For complete package dimensions see reference manual or data sheet.

*For complete package dimensions see reference manual or data sheet.

## Plastic Quad Flatpack (PQFP)

| ADI Letter <br> Designator | PMI Letter <br> Designator | Product <br> Description | $\mathbf{a}^{\star}$ |  | $\mathrm{b}^{\star}$ |  | $c^{\star}$ |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max | Min | Max | Min | Max |
| S-44 |  | 44-Terminal | 0.390 (9.91) | 0.398 (10.11) | 0.390 (9.91) | 0.398 (10.11) |  | 0.096 (2.44) |
| S-52 |  | 52-Terminal | 0.390 (9.91) | 0.398 (10.11) | 0.390 (9.91) | 0.398 (10.11) | 0.084 (2.13) | 0.094 (2.39) |
| S-64 |  | 64-Terminal |  | 0.787 (20.0) |  | 0.551 (14.0) |  | 0.122 (3.10) |
| S-80 |  | 80-Terminal | 0.7834 (19.90) | 0.7913 (20.10) | 0.6948 (17.65) | 0.7145 (18.15) |  | 0.1338 (3.40) |
| S-160 |  | 160-Terminal | 1.098 (27.89) | 1.106 (28.09) | 1.096 (27.84) | 1.106 (28.09) |  | 0.160 (4.06) |

*For complete package dimensions see reference manual or data sheet.

Thin Quad Flatpack (TQFP)


| ADI Letter Designator | PMI Letter Designator | Product Description | a* |  | $\mathbf{b}^{\star}$ |  | c* |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max | Min | Max | Min | Max |
| ST-48 |  | 48-Lead | 0.272 (6.91) | 0.280 (7.11) | 0.272 (6.91) | 0.280 (7.11) |  | 0.067 (1.70) |
| ST-64 |  | 64-Lead | 0.547 (13.89) | 0.556 (14.12) | 0.547 (13.89) | 0.556 (14.12) |  | 0.063 (1.60) |

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## Package Information-Outline Dimensions



Thin Small Outline Package (TSOP)

| ADI Letter | PMI Letter | Product |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Designator | Designator | Description | Min | Max | Min | Max | Min | Max |
| U-32 |  | 32-Lead | 0.720 (18.30) | 0.728 (18.50) | 0.307 (7.80) | 0.323 (8.20) | 0.037 (0.94) | 0.0410 (1.04) |

*For complete package dimensions see reference manual or data sheet.


## Leaded Chip Carrier (Ceramic)

| ADI Letter Designator | PMI Letter Designator | Product <br> Description | $\mathbf{a}^{\star}$ |  | $\mathbf{b}^{\star}$ |  | ${ }^{\star}$ * |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max | Min | Max | Min | Max |
| Z-8A |  | 8-Lead | 0.250 (6.35) | 0.260 (6.60) | 0.250 (6.35) | 0.260 (6.60) | 0.018 (0.46) | 0.098 (2.49) |
| Z-16A |  | 16-Lead | 0.442 (11.23) | 0.458 (11.63) | 0.442 (11.23) | 0.458 (11.63) | 0.103 (2.62) | 0.133 (3.38) |
| Z-16B |  | 16-Lead | 0.542 (13.77) | 0.558 (14.17) | 0.542 (13.77) | 0.558 (14.17) | 0.113 (2.87) | 0.143 (3.63) |
| Z-16C |  | 16-Lead | 0.391 (9.93) | 0.405 (10.29) | 0.2 (6.3) | 0.260 (6.60) | 0.018 (0.46) | 0.098 (2.49) |
| Z-28 |  | 28-Lead | 0.710 (18.03) | 0.730 (18.54) | 0.490 (12.45) | 0.510 (12.95) |  |  |
| Z-40 |  | 40-Lead | 2.074 (52.68) | 2.116 (53.75) | 1.079 (27.41) | 1.101 (27.97) |  | 0.217 (5.51) |
| Z-68 |  | 68-Lead | 0.940 (23.88) | 0.960 (24.38) | 0.940 (23.88) | 0.960 (24.38) | 0.092 (2.34) | 0.118 (2.997) |

*For complete package dimensions see reference manual or data sheet.

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Product Families Still Available . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 24-4
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Substitution Guide for Product Families No Longer Available . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 24-7
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## Ordering Guide

## INTRODUCTION

This Ordering Guide should make it easy to order Analog Devices products. It will help you:

1. Find the correct part number for the options you want.
2. Get a price quotation and place an order with us, or one of our authorized distributors.
3. Know our warranty for components and subsystems.

For answers to further questions, call the nearest sales office (listed on pages 24-16 and 24-17) or our main office in Norwood, Massachusetts U.S.A. (617-329-4700).

## MODEL NUMBERING

In this reference manual many of the data sheets for products having a number of standard options contain an Ordering Guide. Use it to specify the correct part number for the exact combination of options you want. Two model numbering schemes are used by Analog Devices. The first model numbering scheme is used for designating standard Analog Devices monolithic and hybrid products. The second scheme is used by our Precision Monolithics Division (formerly PMI) as designators for its product line.
Figure 1 shows the form of model number used for our proprietary standard monolithic ICs and many of our hybrids. It consists of an "AD" (Analog Devices) prefix, a 3-to-5-digit number,* an alphabetic performance/temperature-range designator and a package designator. One or two additional letters may immediately follow the digits ("A" for second-generation redesigned ICs, "DI" for dielectrically isolated CMOS switches, e.g., AD536AJH, AD7512DIKD).
Figure 2 shows a different numbering scheme used by our Precision Monolithics Division. This numbering scheme starts with a prefix which designates the device type and model number. It is then followed by a suffix consisting of alphabetic designators (as applicable) to indicate additional functional designations or options and packaging options.


Figure 1. Model-Number Designations for Standard Analog Devices Monolithic and Hybrid IC Products. S, $T$ and $U$ Grades Have the Added Suffix /883B for Devices that Qualify to the Latest Revision of MIL-STD-883, Level B.

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Figure 2. Precision Monolithics Division's Product Designations

## ORDERING FROM ANALOG DEVICES

When placing an order, please provide specific information regarding model type, number, option designations, quantity, ship-to and bill-to address. Prices quoted are list; they do not include applicable taxes, customs, or shipping charges. All shipments are F.O.B. factory.
Eligible customers may place their orders through our regional customer service centers by dialing 1-800-262-5645 (U.S.A. only) or through our representatives or authorized distributors. (The telephone numbers for our representatives or authorized distributors are listed on pages 24-16 and 24-17.) Analog Devices' minimum order value is $\$ 500.00$.

## WARRANTY AND REPAIR CHARGE POLICIES

All Analog Devices, Inc., products are warranted against defects in workmanship and materials under normal use and service for one year from the date of their shipment by Analog Devices, Inc., except that components obtained from others are warranted only to the extent of the original manufacturers' warranties, if any, except for component test systems, which have a 180-day warranty. This warranty does not extend to any products which have been subjected to misuse, neglect, accident, or improper installation or application, or which have been repaired or altered by others. Analog Devices' sole liability and the Purchaser's sole remedy under this warranty is limited to repairing or replacing defective products. (The repair or replacement of defective products does not extend the warranty period. This warranty does not apply to components which are normally consumed in operation or which have a normal life inherently shorter than one year.) Analog Devices, Inc., shall not be liable for consequential damages under any circumstances.

## Product Families Still Available

The information published in this Reference Manual is intended to assist the user in choosing components for the design of new equipment, using the most cost-effective products available from Analog Devices. The popular product types listed below may have been designed into your circuits in the past, but they are no longer likely to be the most economic choice for your new designs. Nevertheless, we recognize that it is often a wise choice to refrain from redesigning proven equipment, and we are continuing to make these products available for use in existing designs. Data sheets on these products are available upon request.

| Model | Model | Model | Model | Model |
| :---: | :---: | :---: | :---: | :---: |
| AC1226 | AD532 | AD2700 | AD7576 | ADC1130 |
| AC2626 | AD533 | AD2701 | AD7578 | ADC1131 |
| AD2S44 | AD535 | AD2702 | AD7579 | ADC1140 |
| AD2S47 | AD545 | AD2710 | AD7580 | ADC1143 |
| AD2S65 | AD545A | AD2712 | AD7581 | AD DAC08 |
| AD2S66 | AD561 | AD5200 Series | AD7582 | AD DAC71 |
| AD2S75 | AD562 | AD5210 Series | AD7586 | AD DAC72 |
| AD2S110 | AD563 | AD7001 | AD7590DI | ADEB770 |
| AD203 | AD567 | AD7002 | AD7592DI | ADG221 |
| AD230 | AD572 | AD7010 | AD7672 | ADG222 |
| AD231 | AD578 | AD7011 | AD7716 | ADG445 |
| AD231A | AD579 | AD7110 | AD7769 | ADG506A |
| AD232 | AD582 | AD7118 | AD7773 | ADG507A |
| AD232A | AD611 | AD7228 | AD7774 | ADG526A |
| AD233 | AD632 | AD7237 | AD7775 | ADG527A |
| AD233A | AD639 | AD7240 | AD7820 | ADG528A |
| AD234 | AD651 | AD7245 | AD7848 | ADG529A |
| AD235 | AD675 | AD7247 | AD7850 | AD OP07 |
| AD236 | AD730 | AD7248 | AD9003 | AD OP27 |
| AD237 | AD741 | AD7341 | AD9003A | AD OP37 |
| AD238 | AD773 | AD7371 | AD9005A | ADSP-1008A |
| AD239 | AD774 | AD7501 | AD9007 | ADSP-1009A |
| AD241 | AD796 | AD7502 | AD9014 | ADSP-1010A |
| AD246 | AD803 | AD7503 | AD9034 | ADSP-1010B |
| AD346 | AD805 | AD7506 | AD9502 | ADSP-1012A |
| AD363 | AD880 | AD7507 | AD9505 | ADSP-1016A |
| AD363R | AD890 | AD7510DI | AD9560 | ADSP-1024A |
| AD364 | AD891 | AD7511DI | AD9610 | ADSP-1080A |
| AD364R | AD891A | AD7512DI | AD9611 | ADSP-1081A |
| AD365 | AD892T/E | AD7520 | AD9686 | ADSP-1101 |
| AD380 | AD896 | AD7522 | AD9703 | ADSP-1110A |
| AD386 | AD897 | AD7523 | AD22001 | ADSP-1401 |
| AD389 | AD899 | AD7525 | AD22050 | ADSP-1402 |
| AD390 | AD1139 | AD7533 | AD22150 | ADSP-1410 |
| AD394 | AD1154 | AD7534 | AD75019 | ADSP-3128A |
| AD395 | AD1170 | AD7535 | AD75069 | ADSP-3201 |
| AD396 | AD1315 | AD7536 | AD75089 | ADSP-3202 |
| AD503 | AD1317 | AD7541 | AD75090 | ADSP-3210 |
| AD504 | AD1320 | AD7541A | AD79024 | ADSP-3211 |
| AD506 | AD1324 | AD7542 | AD ADC71 | ADSP-3212 |
| AD507 | AD1334 | AD7543 | AD ADC72 | ADSP-3220 |
| AD507SH/883B | AD1341 | AD7545 | AD ADC80 | ADSP-3221 |
| AD510 | AD1362 | AD7545A | AD ADC84 | ADSP-3222 |
| AD515 | AD1376 | AD7546 | AD ADC85 | ADV101 |
| AD515A | AD1377 | AD7548 | ADC170 | ADV453 |
| AD517 | AD1378 | AD7549 | ADC908 | ADV471 |
| AD518 | AD1380 | AD7572 | ADC910 | ADV473 |
| AD521 | AD1403 | AD7572A | ADC912 | ADV475 |
| AD522 | AD2026 | AD7574 | ADC912A | ADV476 |


| Model | Model | Model | Model | Model |
| :---: | :---: | :---: | :---: | :---: |
| ADV477 | DRC1745 | OP227 | PM7628 | 1B41 |
| ADV478 | DRC1746 | OP260 | PM7645 | 1B51 |
| ADV7120 | HDS1240E | OP421 | REF03 | 1S74 |
| ADV7121 | HDS1250A | OSC1758 | REF05 | 2B20 |
| ADV7122 | HOS050/050A/050C | PKD01 | REF08 | 2B22 |
| ADV7128 | HOS060/060A | PM108/208/308 | REF10 | 2B23 |
| ADV7141 | HTC0300A | PM111/211 | RPT82 | 2B24 |
| ADV7146 | HTS0010 | PM119 | RPT83 | 2B31 |
| ADV7148 | HTS0025 | PM139 | RPT85 | 2B34 |
| ADV7150 | IPA1764 | PM148/248 | RPT86 | 2B50 |
| ADV7151 | JM38510/11301/11302 | PM155 | RPT87 | 2B52 |
| ADV7152 | LIU01 | PM155A | SDC1740/RDC1740 | 2B53 |
| ADVFC32 | MUX88 | PM156 | SDC1741/RDC1741 | 2B54 |
| AMP03 | OP01 | PM156A | SDC1742/RDC1742 | 2B55 |
| AMP05 | OP02 | PM157 | SMP10 | 2B56 |
| BUF03 | OP04 | PM157A | SMP11 | 2B57 |
| CAV1210 | OP05 | PM219 | SMP81 | 2B58 |
| CMP01 | OP06 | PM239 | SSM2013 | 2B59 |
| CMP02 | OP08 | PM248 | SSM2014 | 2S50 |
| CMP05 | OP09 | PM308 | SSM2015 | 2S80A |
| CMP08 | OP10 | PM355 | SSM2016 | 2S81A |
| CMP404 | OP11 | PM356 | SSM2018 | 2S82A |
| DAC01 | OP12 | PM562 | SSM2044 | 3B Series |
| DAC02/03 | OP14 | PM725 | SSM2045 | 4B Series |
| DAC05/06 | OP15 | PM741 | SSM2047 | 5B Series |
| DAC10 | OP16 | PM747 | SSM2100 | 6B Series |
| DAC20 | OP17 | PM0820 | SSM2110 | 7B Series |
| DAC86 | OP20 | PM0828 | SSM2120 | 277 |
| DAC88 | OP21 | PM1008 | SSM2122 | 281 |
| DAC89 | OP22 | PM1012 | SSM2125 | 284J |
| DAC100 | OP32 | PM2108 | SSM2126 | 286J |
| DAC210 | OP41 | PM4136 | SSM2131 | 289 |
| DAC888 | OP43 | PM6012 | SSM2132 | 290 |
| DAC1136 | OP44 | PM7224 | SSM2134 | 290A |
| DAC1138 | OP50 | PM7226 | SSM2139 | 292 |
| DAC1146 | OP61 | PM7226A | SSM2210 | 292A |
| DAC1408A | OP64 | PM7524 | SSM2220 | 310 |
| DAC1508A | OP65 | PM7528 | SSM2300 | 365 |
| DAC8012 | OP80 | PM7533 | SW01/02 | 429 |
| DAC8143 | OP111 | PM7541 | SW201 | 451 |
| DAC8212 | OP147 | PM7541A | SW202 | 453 |
| DAC8841 | OP150 | PM7542 | SW7510/7511 | 460 |
| DAS1152 | OP160 | PM7543 | 1B21 | 741A |
| DAS1153 | OP166 | PM7545 | 1B22 | 755 |
| DAS1158 | OP207 | PM7548 | 1B31 | 757 |
| DAS1159 | OP215 | PM7574 | 1B32 | 759 |
|  |  |  |  | 950 |

## DSP Reference Manual Product Families

Analog Devices offers a wide variety of high performance DSP products. These products are not included in this manual because our new Digital Signal Processing Reference Manual is scheduled for publication in late 1994. That reference manual will provide complete data sheets for the design-in products listed below.

## Model

AD28msp01
AD28msp02
AD1848
AD1849
AD1851
AD1856
AD1860
AD1864
AD1865
AD1866
AD1868
AD1878
AD1879
ADDS-2100A-ICE
ADDS-2101-EZ
ADDS-2101-ICE
ADDS-2111-EZ
ADDS-2111-ICE
ADDS-21msp50-EZ
ADDS-21msp50-ICE
ADDS-21xx-Software
ADDS-21020-EZ
ADDS-210xx-Software
ADSP-2100
ADSP-2100A
ADSP-2101
ADSP-2102
ADSP-2103
ADSP-2105
ADSP-2106
ADSP-2111
ADSP-2112
ADSP-2115
ADSP-21msp50A
ADSP-21msp51
ADSP-21msp55A
ADSP-21msp56A
ADSP-21010
ADSP-21020

## Substitution Guide

The products listed in the left-hand column are no longer available from Analog Devices. In many cases, comparable functions and performance may be obtained with newer models, but-as a rule-they are not directly interchangeable. The closest recommended Analog Devices equivalent, physically and electrically, is listed in the right-hand column. If no equivalent is listed, or for further information, contact your local sales office.

| Model | Closest <br> Recommended Equivalent | Model | Closest <br> Recommended <br> Equivalent | Model | Closest <br> Recommended Equivalent |
| :---: | :---: | :---: | :---: | :---: | :---: |
| AD2S34 | None | AD1147/48 | AD669 | AD7527 | AD7548 |
| AD2S46 | None | AD1175 | RTI870 | AD7530 | AD7533 |
| AD101A | PM1008 | AD1321 | AD1324 | AD7531 | AD7541A |
| AD108/208/308 | AD705 | AD1322 | AD1324 | AD7544 | AD7548 |
| AD108A/208A/308A | AD705 | AD1332 | None | AD7550 | Consult ADI |
| AD111/211/311 | AD790 | AD1408 | AD558 | AD7552 | Consult ADI |
| AD201A | PM2008 | AD1508 | AD558 | AD7555 | Consult ADI |
| AD206 | None | AD1678 | AD678 | AD7560 | None |
| AD293 | AD210 | AD1679 | AD679 | AD7570 | AD7579/AD7580 |
| AD294 | AD210 | AD1779 | AD779 | AD7571 | AD7579/AD7580 |
| AD295 | AD210 | AD1885 | None | AD7583 | AD7880+MUX |
| AD301A | PM3008 | AD2002 | None | AD7772 | Consult ADI |
| AD345 | AD1324 | AD2003 | None | AD9005 | AD9005B |
| AD351 | AD790 | AD2004 | None | AD9006 | None |
| AD362 | AD1362 | AD2006 | None | AD9011 | AD9002 |
| AD367 | None | AD2008 | None | AD9016 | None |
| AD368 | None | AD2009 | None | AD9020SE/883B | AD9020SZ/883B |
| AD369 | None | AD2010 | None | AD9020TE/883B | AD9020TZ/883B |
| AD370/371 | AD767 | AD2016 | None | AD9028 | None |
| AD376 | AD1376 | AD2020 | None | AD9038 | None |
| AD381 | AD744 | AD2021 | None | AD9040 | AD9040A |
| AD382 | AD744/AD845 | AD2022 | None | AD9060SE/883B | AD9060SZ/883B |
| AD392 | AD664 | AD2023 | None | AD9060TE/883B | AD9060TZ/883B |
| AD395/883B | AD394/883B | AD2024 | None | AD9300TE/883B | AD9300TQ/883B |
| AD501 | AD711 | AD2025 | None | AD9521 | AD640 |
| AD502 | AD711 | AD2027 | None | AD9615 | AD9611/AD9617 |
| AD505 | AD843 | AD2028 | None | AD9630AQ | AD9630AN |
| AD506SH/883B | AD42626 | AD2033 | None | AD9630SQ/883B | AD9630AN |
| AD508 | AD517 | AD2036 | None | AD9685 | AD96685 |
| AD509 | AD843 | AD2037 | None | AD9687 | AD96687 |
| AD511 | AD711 | AD2038 | None | AD9688 | AD9002 |
| AD512 | AD711 | AD2040 | None | AD9712 | AD9712B |
| AD513 | AD711 | AD2050 | None | AD9713 | AD9713B |
| AD514 | AD711 | AD2051 | None | AD9768JQ | AD9768JD |
| AD516 | AD711 | AD2060 | None | AD9768SQ | AD9768SD |
| AD520 | AD524 | AD2061 | None | AD9768SE | AD9768SD |
| AD523 | AD549 | AD2070 | None | AD9950 | AD9955 |
| AD528 | AD711/744 | AD2071 | None | AD75062 | None |
| AD530 | AD533 | AD3554 | None | AD75068 | None |
| AD531 | AD532 | AD3860 | AD567 | AD ADC816 | AD7820/AD7821 |
| AD540 | AD544 | AD5010/6020 | AD9000 | ADC8S | AD673 |
| AD559 | AD557/AD558 | AD5201 | AD578 | ADC10Z | AD574A |
| AD565 | AD565A | AD5202 | AD5212 | ADC12QL | AD7578 |
| AD566 | AD566A | AD5204 | AD5214 | ADC12QM | None |
| AD575 | AD573 | AD5205 | AD5215 | ADC12QZ | AD574A |
| AD583 | AD585 | AD5211 | AD578 | ADC14I/17I | AD1170 |
| AD612 | AD524 | AD5240 | AD ADC85 | ADC16Q | None |
| AD614 | AD524 | AD6012 | AD565A | ADC1100 | AD1170 |
| AD674A | AD674B | AD7005 | AD7011/AD7013 | ADC1102 | AD7870 |
| AD682 | AD781 | AD7115 | AD7111 | ADC1103 | AD7572A |
| AD689 | AD587 | AD7513 | ADG201A | ADC1105 | Consult ADI |
| AD770 | Consult ADI | AD7516 | AD7510DI | ADC1109 | AD7572A |
| AD801 | AD711 | AD7519 | None | ADC1111 | AD574A |
| AD1145 | AD7846 | AD7521 | .AD7541A | ADC1121 | AD7880 |


|  |  |  |  |  |  |
| :--- | :--- | :--- | :--- | :--- | :--- |
|  | Closest |  | Closest |  | Closest |
|  | Recommended |  | Recommended |  | Recommended |
| Model | Equivalent | Model | Equivalent | Model | Equivalent |
| ADC1123 | AD7880 | DAC1108 | AD568 | MAS1202 | AD9005B |
| ADC1133 | AD574A | DAC1112 | AD667 | MAT01/883C | MAT01AH/883C |
| ADCQM | None | DAC1117 | None | MAT02BH | MAT02AH |
| ADCQU | AD574A | DAC1118 | AD767 | MAT02BH/883C | MAT02AH/883C |
| AD DAC100 | AD561 | DAC1122 | AD7541A | MATV0811 | AD9012/48 |
| ADG200 | None | DAC1125 | AD7533 | MATV0816 | AD9012/48 |
| ADG201 | ADG201A | DAC1132 | AD667 | MATV0820 | AD9012/48 |
| ADLH0032 | None | DAC1137 | None | MCI1794 | AD2S80A/82A |
| ADLH0033 | None | DAC1408-6P | DAC1408-8P | MDA Family | AD9712BB/13B |
| ADLH0032G/CG | AD843 | DAC1408-7P | DAC1408-8P | MDD Series | AD9713B |
| ADLH0033G/CG | AD9620/AD9630 | DAC1408-7Q | DAC1408-8Q | MDH Family | AD9712B/13B |
| ADM501 | None | DAC1408-GQ | DAC1408-8Q | MDMS Family | AD9712B/13B |
| ADP501 | None | None | MDS Family | AD9712B/13B |  |
| ADREF01 | REF01 | DAC1420 | None | MDSL Family | AD9712B/13B |
| ADREF02 | REF02 | DAC1422 | None | MOD1005/20 | AD9020/60 |
| ADSHC85 | AD585 | DAC1423 | DAC1508A-8Q | DAC1408-8Q | MOD1205 |


| Model | Closest <br> Recommended <br> Equivalent | Model | Closest <br> Recommended Equivalent | Model | Closest <br> Recommended Equivalent |
| :---: | :---: | :---: | :---: | :---: | :---: |
| OP17FZ | OP17EZ | SHA3 | AD585 |  |  |
| OP20CJ | OP20BJ | SHA4 | AD585 | 146 | AD382 |
| OP21GRBC | OP21GBC | SHA5 | None | 148 | AD549 |
| OP215BJ | OP215AJ | SHA6 | None | 149 | AD844 |
| OP215BJ/883C | OP215AJ/883C | SHA1114 | AD585 | 153 | AD517 |
| OP215BZ | OP215AZ | SHA1134 | None | 161 | None |
| OP215CZ/883C | OP215BZ/883 | SHA1144 | None | 163 | None |
| OP21BJ | OP21AJ | SHC85 | AD585 | 165 | None |
| OP21BZ | OP21AZ | SHM5/SHM5K | None | 170 | None |
| OP21EJ | OP21AJ | SMP10BY | SMP10AY | 171 | None |
| OP220BJ | OP220AJ | SMP10BY/ | SMP10AY/ | 180 | AD OP07 |
| OP22AJ | OP22AJ/883C | 883C | 883C | 183 | AD707 |
| OP22EJ | OP22AJ/883C | SPA1695 | None | 184 | AD707 |
| OP32BZ | OP32AZ | SSCT1621 | AD2S80A/82A | 220 | None |
| QMX01 | None | SSCT1622/23 | None | 230 | None |
| RDC1725 | Consult ADI | STB03 | None | 231 | None |
| RDC1726 | Consult ADI | STM Series | Consult ADI | 232 | None |
| RDC1728 | Consult ADI | SW01BQ | SW01FQ | 233 | None |
| RDC1767 | Consult ADI | SW7510AQ | SW7510EQ | 234 | None |
| RDC1768 | Consult ADI | SW7510BQ | SW7510FQ | 235 | None |
| RSCT1621 | AD2S80A/82A | SW7511AQ | SW1577BQ | 260 | AD707 |
| RTI870 | None | THC Family | HTC0300A | 261 | OP177 |
| RTI980 | None | THS Family | HTC0300A | 272 | None |
| RTI1200 | RTI711 Series | TSL1612 | Consult ADI | 273 | None |
| RTI1201 | RTI711 Series | 1S10/20 | AD2S80A/82A | 274J | 284J |
| RTI1202 | RTI711 Series | 1S14/24/44/64/74 | AD2S83 | 275 | AD210 |
| RTI1230 | None | 1S60/61 | AD2S80A/82A | 276 | None |
| RTI1231 | None | 2B30 | 2B31 | 279 | 286J |
| RTI1232 | None | 2B35 | None | 280 | 281 |
| RTI1240 | None | 2S20 | AD2S80A/82A | 282J | 292A |
| RTI1241 | None | 2S54 | Consult ADI | 283J | 292A |
| RTI1242 | None | 2S56 | Consult ADI | 285 | Consult ADI |
| RTI1243 | None | 2S58 | Consult ADI | 287 | None |
| RTI1250 | None | 5S70/5S72 | AD2S75 | 288 | AD210 |
| RTI1251 | None | 9S70/71/72 | None | 293 | AD210 |
| RTI1252 | None | 9S75/76/79 | None | 294 | AD210 |
| RTI1270 | None | 40 | AD711 | 301 | 310 (Module) |
| RTM Series | Consult ADI | 41 | AD515A | 302 | 310 (Module) |
| SAC1763 | None | 42 | AD549 | 311 | AD549 |
| SBCD1752/53/ |  | 43 | AD549 | 350 | None |
| 56/57 | None | 44 | AD845 | 422 | None |
| SCDX1623 | None | 45 | AD744 | 424 | AD534 |
| SCM1677 | None | 46 | AD844 | 425 | AD534 |
| SDC1602/3/4 | Consult ADI | 47 | AD845 | 426 | AD534 |
| SDC1700 | Consult ADI | 48 | AD845 | 427 | None |
| SDC1702 | Consult ADI | 50 | AD844 | 428 | AD538 |
| SDC1703 | Consult ADI | 51 | AD844 | 432 | None |
| SDC1704 | Consult ADI | 52 | AD707 | 433 | AD534 |
| SDC1711 | None | 102 | AD845 | 434 | AD534 |
| SDC1721 | None | 106 | AD711 | 435 | AD734 |
| SDC1725 | Consult ADI | 107 | AD711 | 436 | AD734 |
| SDC1726 | Consult ADI | 108 | AD845 | 440 | None |
| SDC1728 | Consult ADI | 110 | AD845 | 441 | None |
| SDC1767 | Consult ADI | 118 | AD711 | 442 | None |
| SDC1768 | Consult ADI | 120 | AD844 | 450 | AD652 |
| SERDEX | None | 141 | AD711 | 452 | None |
| SHA1A | AD585 | 142 | AD845 | 454 | AD537 |
| SHA2A | AD781 | 143 | AD845 | 456 | AD537 |

## 24

|  |  |
| :--- | :--- |
|  | Closest <br> Recommended <br> Equivalent |
| Model | 460 |
| 458 | AD524 |
| 602 J 10 | AD524 |
| 602 J 100 | AD524 |
| 602 K 100 | AD524 |
| 603 | AD524 |
| 605 | AD625 |
| 606 | AD625 |
| 610 | None |
| 751 | 759 |
| 752 | None |
| 756 | 9022 |
| 901 | 905 |
| 903 | 9022 |
| 904 | 905 |
| 906 | None |
| 907 | None |
| 908 | None |
| 909 | 9022 |
| 915 | None |
| 921 | None |
| 926 | None |
| 927 | 922 |
| 928 | None |
| 931 | None |
| 932 | None |
| 933 | None |
| 935 | None |
| 942 | None |
| 944 | None |
| 946 | Consult ADI |
| 947 | Consult ADI |
| 948 | None |
| 951 | 970 |
| 952 | 966 |
| 953 | None |
| 956 | 960 |
| 959 | None |
| 964 | 940 |
| 965 | None |
| 967 | None |
| 968 | None |
| 971 |  |
| 972 | 977 |
| 973 |  |
| 977 |  |

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SPECIAL LINEAR REFERENCE MANUAL-1992. Data sheets and selection guides to Analog Multipliers/Dividers, Signal Compression Components, RMS-to-DC Converters, Mass Storage Components, ATE Components, Special Function Components, Matched Transistors, Temperature Sensors, Signal Conditioning Components, Automotive Components, Digital Signal Processing Products, Mixed-Signal ASICs, Power Supplies.
DATA CONVERTER REFERENCE MANUAL-1992:
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MILITARY/AEROSPACE REFERENCE MANUAL-1994. Information and data on products available with processing in accordance with MIL-STD-883. Data sheets and selection guides on Operational Amplifiers, A/D and D/A Converters, Digital Signal Processing, Instrumentation Amps, Multipliers/ Dividers, V/F \& F/V Converters, Switches \& Multiplexers, Sample/Track-Hold Amplifiers, Voltage References and Special Function Components.
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ESD Prevention Manual-Protecting ICs from electrostatic discharges. Thirty pages of information that will assist the reader in implementing an appropriate and effective program to assure protection against electrostatic discharge (ESD) failures.
High-Speed Op Amp Sliding Selection Guide. A slide rule for selecting op amps by bandwidth or viewing characteristics by model number. Lists dynamic specs such as slew rate, settling time, differential gain and phase, voltage and current noise, supply voltage and current, and many more.
Instrumentation Amplifier Application Guide, by Charles Kitchin and Lew Counts. Its 44-pages include basic instrumentationamplifier ("in-amp") theory, design considerations, applications, specifications, and products-plus a brief bibliography and two indexes (by topic and by device model number).
Multiple Digital-to-Analog Converter Integrated Circuits Selection Guide. A 32-page guide for the designer who wants to save space and cost in applications calling for from two to eight or more DACs and resolutions from 6 to 18 bits. Devices include triple 6 -, 8 -, and 10 -bit video DACs, dual 18 -bit audio DACs, 8 -bit octuples, and 12- and 14-bit quads.
New Audio Signal Processing Integrated Circuits, including Op Amps, DSP microcomputers, Codecs, Line Driver \& Receiver, VCA, Preamps, Switches, Decoders, Asynchronous sample-rate converters, Stereo ADCs. A 12-page brochure.
Personal Sound Architecture. An 8-page brochure describing a programmable architecture for integrating sound into personal computers using software-based technologies and IC chipsets (including Analog Devices DSPs, codecs, and other peripherals) for sound cards.

## RMS-to-DC Conversion Application Guide 2nd Edition by

 C. Kitchin and L. Counts (1986-61 pages). RMS-DC Conversion: Theory, Basic Design Considerations; RMS ApplicationCircuits; Testing Critical Parameters; Input Buffer Amplifier Requirements; Programs for Computing Errors, Ripple and Settling Time.
Sampling Analog-to-Digital Converter Integrated Circuits-1992 Short Form Selection Guide. Its 28 pages cover 35 different models with resolutions from 8 to 16 bits, and 12-bit resolution up to 20 Msps . Besides block diagrams and key specs of each product, the booklet includes a detailed discussion of selection issues and a selection table sorted by resolution and speed.
Solutions for Cellular Radio Base Stations, 6-page reference guide-describes system architectures for cellular, other wireless, and satellite VSAT stations and lists suitable ADI components for each stage of the signal chain; includes all-digital systems using DSP technology.
Surface Mount IC. * A 28 -page guide to ICs in SO and PLCC packages. Products include op amps, rms-to-dc converters, DACs, ADCs, VFCs, sample-holds and CMOS switches.
A Tutorial in AC Induction and Permanent Magnet Synchronous Motors - Vector Control with Digital Signal Processors. An 80-page Guide, including Overview of AC drives, Synchronous machine operation, Induction motors, Pulse-width modulation, Inverter fed drive scheme, Vector control of AC machines, Field-oriented control of DC motors, Implementation of fieldoriented control in DSP, and References.

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## ANALOG DEVICES <br> WORLDWIDE HEADQUARTERS

One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106, U.S.A. Tel: (617) 329-4700, Fax: (617) 326-8703

Complete Worldwide Sales Office Directory Can Be Found on Pages 24-16 and 24-17.


[^0]:     reference is pinned out.
    ${ }^{2}$ This column lists the data format for the bus with " $\mu \mathrm{P}$ " indicating microprocessor capability-i.e., for a 12 -bit converter $8 / 12$, $\mu \mathrm{P}$ indicates that the data can be formatted for an 8 -bit bus or can be in parallel ( 12 bits) and is microprocessor compatible.
    
    
    
     temperature designator will be followed by: / to indicate 883 B , for JAN, ${ }_{\mathrm{D}}$ for SMD, and ${ }_{\mathrm{S}}$ for space level.
    ${ }^{5}$ CII = Data Converter Reference Manual, Volume II. All other entries refer to this volume.
    Boldface Type: Data sheet information in this volume.

[^1]:    ${ }^{*}$ Covered by Patent Nos. 3,940,760; 4,213,806; 4,136,349.

[^2]:    *Protected by U.S. Patent Nos. 3,803,590; 4,213,806; 4,511,413; RE 28,633.

[^3]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^4]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^5]:    NOTES
    ${ }^{1}$ For details on grade and package offerings screened in accordance with MIL-STD-883 refer to the Analog Devices Military Products Databook.
    ${ }^{2}$ D = Ceramic DIP; N = Plastic DIP; P = Plastic Leaded Chip Carrier. For outline information see Package Information section.

[^6]:    ${ }^{*}$ Protected by U.S. Patent Nos. 3,940,760; 4,213,806; 4,136,349; 4,400,689; and 4,400,690

[^7]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^8]:    NOTES
    ${ }^{1}$ Adjustable to zero.
    ${ }^{2}$ Includes internal voltage reference error.
    ${ }^{3}$ Maximum change from $+25^{\circ} \mathrm{C}$ value to the value at $\mathrm{T}_{\text {MIN }}$ or $\mathrm{T}_{\text {MAX }}$.
    ${ }^{4}$ Tested with REF OUT tied to REF IN through $50 \Omega$ resistor, $\mathrm{V}_{\mathrm{CC}}=+16.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-16.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{LOGIC}}=+5.5 \mathrm{~V}$, and outputs in high- Z mode.
    ${ }^{5}$ Tested with REF OUT tied to REF IN through $50 \Omega$ resistor, $\mathrm{V}_{\mathrm{CC}}=+12 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-12 \mathrm{~V}, \mathrm{~V}_{\mathrm{LOGIC}}=+5 \mathrm{~V}$, and outputs in high- Z mode.
    Specifications subject to change without notice.
    Specifications shown in boldface are tested on all devices at final electrical test at $\mathrm{T}_{\text {MIN }},+25^{\circ} \mathrm{C}$, and $\mathrm{T}_{\text {MAX }}$, and results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested.

[^9]:    $\star \mathrm{D}=$ Ceramic DIP; $\mathrm{N}=$ Plastic DIP; $\mathrm{R}=$ Small Outline IC (SOIC). For outline information see Package Information section.

[^10]:    Specifications subject to change without notice.

[^11]:    NOTES
    ${ }^{1}$ Adjustable to zero.
    ${ }^{2}$ Includes internal voltage reference error.
    ${ }^{3}$ Includes internal voltage reference drift.
    ${ }^{4}$ Excludes internal voltage reference drift.
    ${ }^{5}$ With maximum external load applied.
    Specifications subject to change without notice.

[^12]:    *Protected by U.S. Patent Nos. 4,804,960; 4,814,767; 4,833,345; 4,250,445; 4,808,908; RE 30,586

[^13]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^14]:    NOTES
    ${ }^{1}$ Adjustable to zero.
    ${ }^{2}$ Includes internal voltage reference error.
    ${ }^{3}$ Includes internal voltage reference drift.
    ${ }^{4}$ Excludes internal voltage reference drift.
    ${ }^{5}$ With maximum external load applied.
    *\% FSR = percent of full-scale range.

[^15]:    Specifications subject to change without notice.

[^16]:    ${ }^{\star}$ Protected by U.S. Patent Numbers 4,804,960; 4,814,767; 4,833,345; 4,250,445; 4,808,908; RE30,586.

[^17]:    NOTES
    ${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum ratings for extended periods may affect device reliability.
    ${ }^{2}$ LCC Package Only.

[^18]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^19]:    Specifications subject to change without notice.

[^20]:    This is a preliminary data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^21]:    This information applies to a product under development. Its characteristics and specifications are subject to change without notice.

[^22]:    NOTES
    ${ }^{1}$ Conversion rate is operational down to xx kHz without degradation in specified performance.
    ${ }^{2} \mathrm{C}_{\mathrm{L}}=25 \mathrm{pF}$.

[^23]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^24]:    This is a preliminary data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^25]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^26]:    *Protected by U. S. Patent Nos. 4,962,325; 4,250,445; 4,808,908; RE30586.

[^27]:    NOTES
    ${ }^{1}$ To order MIL-STD-883B, Class B processed parts, add /883B to part number. Contact your local sales office for military data sheet.
    ${ }^{2} \mathrm{~N}=$ Plastic DIP; $\mathbf{Q}=$ Cerdip; $\mathrm{R}=$ SOIC. For outline information see Package Information section.
    ${ }^{3}$ Available to $/ 883 \mathrm{~B}$ processing only.

[^28]:    *Protected by U.S. Patent No. 5,134,401.

[^29]:    ${ }^{11}$ This error can be removed using the system calibration capabilities of the AD7712. This error is not removed by the AD7712's self-calibration feature. The offset drift on the AIN2 input is 4 times the value given in the STATIC PERFORMANCE section.
    ${ }^{12}$ The reference voltage range may be restricted by the input voltage range requirement on the $V_{\text {BIAs }}$ input.
    ${ }^{13}$ The AD7712 is tested with the following $\mathrm{V}_{\text {BIAS }}$ voltages. With $\mathrm{AV}_{\mathrm{DD}}=+5 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{~V}_{\text {BIAS }}=+2.5 \mathrm{~V}$; with $\mathrm{AV}_{\mathrm{DD}}=+10 \mathrm{~V}$ and $\mathrm{V}_{\text {SS }}=0 \mathrm{~V}, \mathrm{~V}_{\text {BIAS }}$ $=+5 \mathrm{~V}$ and with $\mathrm{AV}_{\mathrm{DD}}=+5 \mathrm{~V}$ and $\mathrm{V}_{\text {ss }}=-5 \mathrm{~V}, \mathrm{~V}_{\text {BIAS }}=0 \mathrm{~V}$.
    ${ }^{14}$ Sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance.
    ${ }^{15}$ After calibration, if the analog input exceeds positive full scale, the converter will output all 1 s . If the analog input is less than negative full scale, then the device will output all 0 s .
    ${ }^{16}$ These calibration and span limits apply provided the absolute voltage on the AIN1 analog input does not exceed $\mathrm{AV}_{\mathrm{DD}}+30 \mathrm{mV}$ or does not go more negative than $\mathrm{V}_{\mathrm{ss}}-30 \mathrm{mV}$.
    ${ }^{17}$ The offset calibration limit applies to both the unipolar zero point and the bipolar zero point.
    Specifications subject to change without notice.

[^30]:    NOTES
    ${ }^{1}$ Temperature ranges are as follows: A Version, $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; S Version, $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. See also Note 16.
    ${ }^{2}$ Applies after calibration at the temperature of interest.
    ${ }^{3}$ Positive full-scale error applies to both unipolar and bipolar input ranges.
    ${ }^{4}$ These errors will be of the order of the output noise of the part as shown in Table I.
    ${ }^{5}$ Recalibration at any temperature or use of the background calibration mode will remove these drift errors.
    ${ }^{6}$ This common-mode voltage range is allowed provided that the input voltage on $\operatorname{AIN}(+)$ and $\operatorname{AIN}(-)$ does not exceed $\mathrm{AV}_{\mathrm{DD}}+30 \mathrm{mV}$ and $\mathrm{V}_{\mathrm{ss}}-30 \mathrm{mV}$.
    ${ }^{7}$ These numbers are guaranteed by design and/or characterization.
    ${ }^{8}$ The analog inputs present a very high impedance dynamic load which varies with clock frequency and input sample rate. The maximum recommended source resistance depends on the selected gain (see Tables IV and V).
    ${ }^{9}$ The analog input voltage range on the AIN1 ( + ) and AIN2 $(+)$ inputs is given here with respect to the voltage on the AIN1(-) and AIN2(-) inputs. The absolute voltage on the analog inputs should not go more positive than $A V_{D D}+30 \mathrm{mV}$ or go more negative than $\mathrm{V}_{\mathrm{ss}}-30 \mathrm{mV}$.
    ${ }^{10} \mathrm{~V}_{\text {REF }}=\operatorname{REF} \operatorname{IN}(+)-\operatorname{REF} \operatorname{IN}(-)$.
    ${ }^{11}$ The reference input voltage range may be restricted by the input voltage range requirement on the $\mathrm{V}_{\text {BIAS }}$ input.

[^31]:    NOTES
    ${ }^{1}$ To order MIL-STD-883B, Class B processed parts, add /883B to part number. Contact our local sales office for military data sheet and availability.
    ${ }^{2} \mathrm{~N}=$ Plastic DIP; Q = Cerdip; R = SOIC. For outline information see Package Information section.

[^32]:    *AIN( + ) refers to AIN1 ( + ) and AIN2(+) of AD7710 and AIN1(+) of AD7712. AIN(-) refers to AIN1(-) and AIN2(-) of AD7710 and AIN1(-) of AD7712.

[^33]:    ${ }^{1}$ Don't Care on AD7712.
    ${ }^{2}$ Must always be 0 to ensure correct operation of the part.

[^34]:    NOTE
    ${ }^{1}$ Effective resolution is defined as the magnitude of the output rms noise with respect to the input full scale (i.e., $2 \times \mathrm{V}_{\mathrm{REF}} /$ GAIN). The above table applies for a $\mathrm{V}_{\mathrm{REF}}$ of +2.5 V and resolution numbers are rounded to the nearest 0.5 LSB .

[^35]:    NOTE
    ${ }^{1}$ Effective resolution is defined as the magnitude of the output rms noise with respect to the input full scale (i.e., $2 \times \mathrm{V}_{\text {REF }} / \mathrm{GAIN}$ ). The above table applies for $a \mathrm{~V}_{\text {REF }}$ of +2.5 V and resolution numbers are rounded to the nearest 0.5 LSB .

[^36]:    This is a preliminary data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^37]:    *AIN(-) refers to the negative input of the differential input pairs or to AIN6 when referring to the pseudo-differential input configurations

[^38]:    This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

[^39]:    This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

[^40]:    This is a preliminary data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^41]:    This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

[^42]:    This is a preliminary data sheet. To obtain the most recent version or

[^43]:    This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

[^44]:    This information applies to a product under development. Its characteristics and specifications are subject to change without notice.

[^45]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^46]:    NOTES
    ${ }^{1}$ Temperature ranges are as follows: J, $\mathrm{K}, \mathrm{L}$ Versions; 0 to $+70^{\circ} \mathrm{C}: \mathrm{A}, \mathrm{B}, \mathrm{C}$ Versions; $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}: \mathrm{S}, \mathrm{T}$ Versions; $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. AD7870A has only J Version.
    ${ }^{2} \mathrm{~V}_{\mathrm{IN}}(\mathrm{pk}-\mathrm{pk})= \pm 3 \mathrm{~V}$.
    ${ }^{3}$ SNR calculation includes distortion and noise components.
    ${ }^{4}$ Measured with respect to internal reference and includes bipolar offset error.
    ${ }^{5}$ Sample tested @ $+25^{\circ} \mathrm{C}$ to ensure compliance.
    Specifications subject to change without notice.

[^47]:    NOTES
    ${ }^{1}$ Temperature ranges are as follows: AD7875: K, L Versions, 0 to $+70^{\circ} \mathrm{C}$; $\mathrm{B}, \mathrm{C}$ Versions, $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; T Version, $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C} . \mathrm{AD} 7876$ : $\mathrm{B}, \mathrm{C}$ Versions, $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; T Version, $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
    ${ }^{2}$ Includes internal reference error and is calculated after unipolar offset error (AD7875) or bipolar zero error (AD7876) has been adjusted out.
    Full-scale error refers to both positive and negative full-scale error for the AD7876.
    ${ }^{3}$ Dynamic performance parameters are not tested on the AD7876 but these are typically the same as for the AD7875.
    ${ }^{4}$ SNR calculation includes distortion and noise components.
    ${ }^{5}$ Sample tested @ $+25^{\circ} \mathrm{C}$ to ensure compliance.
    Specifications subject to change without notice.

[^48]:    NOTES
    ${ }^{1}$ Temperature ranges are as follows: $\mathrm{J}, \mathrm{K}$ versions, $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C} ; \mathrm{A}, \mathrm{B}$ versions, $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; T version; $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
    ${ }^{2} \mathrm{~V}_{\mathrm{IN}}= \pm 3 \mathrm{~V}$.
    ${ }^{3}$ SNR calculation includes distortion and noise components.
    ${ }^{4}$ Measured with respect to internal reference.
    ${ }^{5}$ Sample tested @ $+25^{\circ} \mathrm{C}$ to ensure compliance.
    Specifications subject to change without notice.

[^49]:    NOTES
    ${ }^{1}$ Temperature ranges are as follows: A, B Versions: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; S Version: $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
    ${ }^{2}$ See Terminology.
    ${ }^{3}$ Sample tested @ $+25^{\circ} \mathrm{C}$ to ensure compliance.
    ${ }^{4}$ Measured with respect to the REF IN voltage and includes bipolar offset error.
    ${ }^{5}$ For capacitive loads greater than 50 pF a series resistor is required.
    Specifications subject to change without notice.

[^50]:    NOTES
    ${ }^{1}$ To order MIL-STD-883, Class B processed parts, add /883B to part number. Contact our local sales office for military data sheet.
    ${ }^{2}$ Analog Devices reserves the right to ship either ceramic (D-28) packages or cerdip (Q-28) hermetic packages.
    ${ }^{3}$ For outline information see Package Information section.
    ${ }^{4}$ Available to $/ 883 \mathrm{~B}$ processing only.

[^51]:    NOTES
    ${ }^{1}$ Temperature range as follows: $\mathrm{J}, \mathrm{K}, \mathrm{L}$ versions: 0 to $+70^{\circ} \mathrm{C}$; A, B versions: $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; S version: $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
    ${ }^{2} \mathrm{~V}_{\mathrm{IN}}= \pm 3 \mathrm{~V}$. See Dynamic Specifications section.
    ${ }^{3}$ SNR calculation includes distortion and noise components.
    ${ }^{4}$ Measured with respect to the Internal Reference.
    ${ }^{\text {s }}$ For Capacitive Loads greater than 50 pF a series resistor is required (see Internal Reference section).
    ${ }^{6}$ Sample tested @ $+25^{\circ} \mathrm{C}$ to ensure compliance.
    Specifications subject to change without notice.

[^52]:    NOTES
    ${ }^{1}$ Timing Specifications in bold print are $100 \%$ production tested. All other times are sample tested at $+25^{\circ} \mathrm{C}$ to ensure compliance. All input signals are specified with $\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of 5 V$)$ and timed from a voltage level of 1.6 V .
    ${ }^{2} \mathrm{t}_{13}$ is measured with the load circuit of Figure 1 and defined as the time required for an output to cross 0.8 V or 2.4 V .
    ${ }^{3} t_{14}$ is derived from the measured time taken by the data outputs to change 0.5 V when loaded with the circuit of Figure 1 . The measured number is then extrapolated back to remove the effects of charging or discharging the 100 pF capacitor. This means that the time, $\mathrm{t}_{14}$, quoted in the Timing Specifications is the true bus relinquish time of the part and as such is independent of external bus loading capacitances.
    Specifications subject to change without notice

[^53]:    This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

[^54]:    NOTES
    ${ }^{1}$ Temperature range is as follows: B Versions: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.
    ${ }^{2} \mathrm{~V}_{\text {IN }}=0$ to $\mathrm{V}_{\mathrm{REF}}$.
    ${ }^{3}$ SNR calculation includes distortion and noise components.
    ${ }^{4}$ Sample tested @ $+25^{\circ} \mathrm{C}$ to ensure compliance.
    Specifications subject to change without notice.

[^55]:    ${ }^{\star} \mathrm{N}=$ Plastic DIP; $\mathrm{R}=$ SOIC (Small Outline Integrated Circuit). For outline information see Package Information section.

[^56]:    NOTES
    ${ }^{1}$ Temperature Ranges are as follows: A, B Versions: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.
    ${ }^{2} \mathrm{~V}_{\mathrm{IN}}= \pm 5 \mathrm{~V}$.
    ${ }^{3}$ The AD7885AAP has the same specs as the AD7884AP.
    The AD7885ABP has the same specs as the AD7884BP.
    ${ }^{4}$ Sample tested to ensure compliance.
    Specifications subject to change without notice.

[^57]:    *Contact your local salesperson for further information on the $\mathbf{1} \mathbf{~ M H z}$ version.

[^58]:    NOTES
    ${ }^{1}$ Burn-in is available on extended industrial temperature range parts in cerdip.
    ${ }^{2}$ A complete / 883 data sheet is available. For availability and burn-in information, contact your local sales office.
    ${ }^{3}$ For outline information see Package Information section.

[^59]:    NOTES
    ${ }^{1}$ All supplies can be varied $\pm 5 \%$, and operation is guaranteed. Device is tested with nominal supplies.
    ${ }^{2}$ Operation is guaranteed over this reference range, but linearity is neither tested nor guaranteed.
    ${ }^{3}$ All input control signals are specified with $\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of $+5 \mathrm{~V})$ and timed from a voltage level of 1.6 V .
    Specifications subject to change without notice.

[^60]:    NOTES
    ${ }^{1}$ All supplies can be varied $\pm 5 \%$, and operation is guaranteed. Device is tested with $\mathrm{V}_{\mathrm{DD}}=+4.75 \mathrm{~V}$.
    ${ }^{2}$ For single supply operation only ( $\mathrm{V}_{\mathrm{REFL}}=0.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=0.0 \mathrm{~V}$ ): Due to internal offset errors, INL and DNL are measured beginning at code $2\left(002_{\mathrm{H}}\right)$.
    ${ }^{3}$ Operation is guaranteed over this reference range, but linearity is neither tested nor guaranteed.
    ${ }^{4}$ All input control signals are specified with $\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of $+5 \mathrm{~V})$ and timed from a voltage level of 1.6 V .
    Specifications subject to change without notice.

[^61]:    NOTES
    ${ }^{1}$ Alll supplies can be varied $\pm 5 \%$ and operation is guaranteed. Device is tested with $V_{D D}=+4.75 \mathrm{Y}$.
    ${ }^{2}$ For single-supply operation ( $\mathrm{V}_{\text {VREFLO }}=0 \mathrm{~V}, \mathrm{~V}_{\text {ss }}=0 \mathrm{~V}$ ), due to internal offset errors INL and DNL are measured beginning at $\mathrm{code}^{003}{ }_{\mathrm{H}}$.
    ${ }^{3}$ Guaranteed but not tested.
    ${ }^{4}$ Operation is guaranteed over this reference range, but linearity is neither tested nor guaranteed.
    ${ }^{5} \mathrm{~V}_{\text {OUT }}$ swing between +2.5 V and -2.5 V with $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}$.
    ${ }^{6} \mathrm{Alll}$ input control signals are specified with $\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of $+5 \mathrm{~V})$ and timed from a voltage level of 1.6 V .
    ${ }^{7}$ Typical values indicate performance measured at $+25^{\circ} \mathrm{C}$.
    Specifications subject to change without notice.

[^62]:    NOTES
    ${ }^{1}$ All supplies can be varied $\pm 5 \%$ and operation is guaranteed.
    ${ }^{2}$ Guaranteed but not tested.
    ${ }^{3}$ Operation is guaranteed over this reference range, but linearity is neither tested nor guaranteed.
    ${ }^{4} \mathrm{~V}_{\text {OUT }}$ swing between +10 V and -10 V .
    ${ }^{5}$ All input control signals are specified with $\mathrm{tr}=\mathrm{tf}=5 \mathrm{~ns}(10 \%$ to $90 \%$ of $+5 \mathrm{~V})$ and timed from a voltage level of 1.6 V .
    ${ }^{6}$ Typical values indicate performance measured at $+25^{\circ} \mathrm{C}$.
    Specifications subject to change without notice.

[^63]:    *For outline information see Package Information section.

[^64]:    NOTES
    ${ }^{1} \uparrow+$ positive logic transition; $\downarrow$ - negative logic transition; $X=$ Don't Care.
    ${ }^{2} \mathrm{CS}$ and CLK are interchangeable.
    ${ }^{3}$ Returning $\overline{\mathrm{CS}}$ HIGH avoids an additional "false clock" of serial data input.
    ${ }^{4}$ Do not clock in serial data while $\overline{\mathrm{LD}}$ is LOW.

[^65]:    SUBSTRATE IS COMMON WITH $V_{D D}$.
    TRANSISTOR COUNT: 524
    DIE SIZE: 0.070 INCH $\times 0.105$ INCH; 7350 SQ MILS

[^66]:    ${ }^{\bullet}$ Protected by Patent Nos. 3,887,963 and RE 30,586.

[^67]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^68]:    *Teflon is a trademark of E. I. Du Pont de Nemours \& Co.

[^69]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^70]:    This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

[^71]:    This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

[^72]:    NOTES
    ${ }^{1}$ Temperature range as follows: $\mathrm{A}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.
    ${ }^{2} 1 \mathrm{LSB}=\left(2 \times \mathrm{V}_{\text {SWING }}\right) / 1024=1.95 \mathrm{mV}$ for $\mathrm{V}_{\text {SWING }}=1.0 \mathrm{~V}$.
    ${ }^{3}$ Guaranteed by design, not production tested.
    Specifications subject to change without notice.

[^73]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^74]:    NOTES
    ${ }^{1}$ Temperature ranges are as follows: A/B Versions, $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; T Version, $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
    $\mathrm{V}_{\mathrm{IN}}= \pm 3 \mathrm{~V}$.
    ${ }^{3}$ SNR calculation includes distortion and noise components.
    ${ }^{4}$ SNR degradation due to asynchronous DAC updating during conversion is 0.1 dB typ.
    ${ }^{5}$ Measured with respect to internal reference.
    ${ }^{6}$ For capacitive loads greater than 50 pF a series resistor is required (see INTERNAL REFERENCE section).
    ${ }^{7}$ Tying the CONTROL input to $\mathrm{V}_{\text {DD }}$ places the device in a factory test mode where normal operation is not exhibited.
    ${ }^{8}$ Sample tested @ $+25^{\circ} \mathrm{C}$ to ensure compliance.
    Specifications subject to change without notice.

[^75]:    * $\mathrm{N}=$ Plastic DIP; $\mathbf{Q}=$ Cerdip; $\mathrm{R}=$ SOIC (Small Outline IC). For outline information see Package Information section.

[^76]:    NOTES
    ${ }^{1}$ Temperature ranges are as follows: J Version, $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$; A Version, $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.
    ${ }^{2} \mathrm{~V}_{\mathrm{IN}}= \pm 3 \mathrm{~V}$.
    ${ }^{3}$ SNR calculation includes distortion and noise components.
    ${ }_{5}^{4}$ SNR degradation due to asynchronous DAC updating during conversion is 0.1 dB typ.
    ${ }^{5}$ Measured with respect to internal reference.
    ${ }^{6}$ For capacitive loads greater than 50 pF a series resistor is required (see Internal Reference section).
    ${ }^{7}$ Tying the CONTROL input to $\mathrm{V}_{\mathrm{DD}}$ places the device in a factory test mode where normal operation is not exhibited.
    ${ }^{8}$ Sample tested @ $+25^{\circ} \mathrm{C}$ to ensure compliance.
    Specifications subject to change without notice.

[^77]:    ${ }^{\star} \mathrm{N}=$ Plastic DIP; Q = Cerdip; R = Small Outine IC (SOIC). For outline information see Package Information section.

[^78]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^79]:    This information applies to a product under development. Its characteristics and specifications are subject to change without notice.
    Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

[^80]:    This information applies to a product under development. Its characteristics and specifications are subject to change without notice.

[^81]:    This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

[^82]:    Specifications subject to change without notice.

[^83]:    Package Options: D = Hermetic DIP, Ceramic or Metal; E = Ceramic Leadless Chip Carrier; F = Ceramic Flatpack; G = Ceramic Pin Grid Array; H = Hermetic Metal Can; J = J-Leaded Ceramic Package;
    
    
     temperature designator will be followed by: / to indicate 883B, ${ }_{\mathrm{J}}$ for JAN, ${ }_{\mathrm{D}}$ for SMD, and ${ }_{\mathrm{s}}$ for space level.
    ${ }^{3} \mathrm{CII}=$ Data Converter Reference Manual, Volume II; $\mathrm{D}=$ Data Sheet. All other entries refer to this volume.
    Boldface Type: Data sheet information in this volume.
    Samplifier is a trademark of Analog Devices, Inc.

[^84]:    ${ }^{1}$ Specified and tested over an input range of $\pm 5 \mathrm{~V}$.
    ${ }^{2}$ Maximum current the AD684 can source (or sink). Testing guarantees that the accuracy of the held signal remains within 2.5 mV of its initial value.
    ${ }^{3}$ The output is protected for a short circuit to common, $\mathrm{V}_{\mathrm{CC}}$ and $\mathrm{V}_{\mathrm{EE}}$.
    ${ }^{4} \mathrm{~V}_{\mathrm{CC}}$ and $\mathrm{V}_{\mathrm{EE}}$ at nominal voltage levels.
    Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels.
    All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.
    Specifications subject to change without notice.

[^85]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^86]:    *See "Matching the AD9101 to A/D Encoders" in complete data sheet. Both pins should either be grounded or connected to voltage source for offset.

[^87]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^88]:    
    
    
     temperature designator will be followed by: / to indicate 883B, ${ }_{\mathrm{J}}$ for JAN, ${ }_{\mathrm{D}}$ for SMD, and ${ }_{\mathrm{s}}$ for space level.
    ${ }^{3}$ CII = Data Converter Reference Manual, Volume II. All other entries refer to this volume.
    Boldface Type: Data sheet information in this volume.

[^89]:    
    
    
     temperature designator will be followed by: / to indicate $883 \mathrm{~B},{ }_{\mathrm{J}}$ for JAN, ${ }_{\mathrm{D}}$ for SMD, and ${ }_{\mathrm{s}}$ for space level.
    ${ }^{3} \mathrm{CII}=$ Data Converter Reference Manual, Volume II. All other entries refer to this volume.
    Boldface Type: Data sheet information in this volume.

[^90]:    NOTES
    ${ }^{1} E=$ Ceramic Leadless Chip Carrier; P = Plastic Leaded Chip Carrier; $Q=$ Cerdip. For outline information see Package Information section.
    ${ }^{2}$ For specifications, refer to Analog Devices Military Products Databook.

[^91]:    *COMMENT: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Only one Absolute Maximum Rating may be applied at any one time.

[^92]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^93]:    ${ }^{1}$ Temperature ranges are as follows: B Versions: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; T Versions: $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
    ${ }^{2}$ Guaranteed by design, not subject to production test.
    Specifications subject to change without notice.

[^94]:    ${ }^{1}$ Temperature ranges are as follows: B Versions: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; T Versions: $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
    ${ }^{2}$ Guaranteed by design, not subject to production test.
    Specifications subject to change without notice.

[^95]:    NOTES
    ${ }^{1}$ Temperature Ranges are as follows: B Versions: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; T Versions: $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
    ${ }^{2}$ Guaranteed by design, not subject to production test.
    Specifications subject to change without notice.

[^96]:    NOTES
    ${ }^{1}$ Temperature Ranges are as follows: B Versions: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; T Versions: $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
    ${ }^{2}$ Guaranteed by design, not subject to production test.
    Specifications subject to change without notice.

[^97]:    NOTES
    ${ }^{1}$ Temperature ranges are as follows: B Versions: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; T Versions: $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
    ${ }^{2}$ Guaranteed by design, not subject to production test.
    Specifications subject to change without notice.

[^98]:    NOTES
    ${ }^{1}$ Temperature ranges are as follows: B Versions: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; T Versions: $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
    ${ }^{2}$ Guaranteed by design, not subject to production test.
    Specifications subject to change without notice.

[^99]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^100]:    NOTES
    ${ }^{1}$ Temperature ranges are as follows: B Versions: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; T Versions: $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
    ${ }^{2}$ Guaranteed by design, not subject to production test.
    Specifications subject to change without notice.

[^101]:    NOTES
    ${ }^{1}$ To order MIL-STD-883, Class B processed parts, add /883B to T grade part numbers.
    ${ }^{2} \mathrm{~N}=$ Plastic DIP, $\mathrm{R}=0.15^{\prime \prime}$ Small Outline IC (SOIC), $\mathrm{Q}=$ Cerdip. For outline information see Package Information section.

[^102]:    This is a preliminary data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^103]:    X = Don't Care

[^104]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^105]:    
    
    
     temperature designator will be followed by: / to indicate $883 \mathrm{~B},{ }_{\mathrm{I}}$ for JAN, ${ }_{\mathrm{D}}$ for SMD, and ${ }_{\mathrm{S}}$ for space level.
    ${ }^{3}$ CII $=$ Data Converter Reference Manual, Volume II. All other entries refer to this volume.
    Boldface Type: Data sheet information in this volume.

[^106]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^107]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^108]:    NOTES
    ${ }^{1}$ Both $\mathrm{V}_{\text {OUT }}$ pads should be connected to the output.
    ${ }^{2}$ Sense and force grounds must be tied together.
    Die Thickness: The standard thickness of Analog Devices Bipolar dice is 24 mils $\pm 2$ mils.
    Die Dimensions: The dimensions given have a tolerance of $\pm 2$ mils.
    Backing: The standard backside surface is silicon (not plated). Analog Devices does not recommend gold-backed dice for most applications.
    Edges: A diamond saw is used to separate wafers into dice thus providing perpendicular edges half-way through the die. In contrast to scribed dice, this technique provides a more uniform die shape and size. The perpendicular edges facilitate handling (such as tweezer pick-up) while the uniform shape and size simplifies substrate design and die attach.
    Top Surface: The standard top surface of the die is covered by a layer of glassivation. All areas are covered except bonding pads and scribe lines.
    Surface Metalization: The metalization to Analog Devices bipolar dice is aluminum. Minimum thickness is $10,000 \AA$.
    Bonding Pads: All bonding pads have a minimum size of 4 mils by 4 mils, The passivation windows have 3.5 mils
    by 3.5 mils minimum.

[^109]:    *Covered by Patent Number 4,644,253

[^110]:    I"Unbuffered" outputs should not be loaded.

[^111]:    ${ }^{\star} N=$ Plastic DIP Package; $\mathbf{R}=$ SOIC Package; $T=$ TO-92 Package. For outline information see Package Information section.

[^112]:    *Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

[^113]:    *Protected by U.S. Patent Numbers: 3,887,863, RE30,586.

[^114]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^115]:    *For outline information see Package Information section.

[^116]:    *Patent pending.

[^117]:    *For outline information see Package Information section.

[^118]:    This is an abridged data sheet. To obtain the most recent version or

[^119]:    Specifications subject to change without notice.

[^120]:    Specifications subject to change without notice.

[^121]:    Specifications subject to change without notice.

[^122]:    ${ }^{1}$ Package Options: D = Hermetic DIP, Ceramic or Metal; E = Ceramic Leadless Chip Carrier; F = Ceramic Flatpack; G = Ceramic Pin Grid Array; H = Hermetic Metal Can; J = J-Leaded Ceramic Package;

[^123]:    
    
    
     temperature designator will be followed by: / to indicate 883B, , for JAN, ${ }_{\mathrm{D}}$ for SMD, and ${ }_{\mathrm{S}}$ for space level.
    ${ }^{3} \mathrm{~A}=$ Amplifier Reference Manual. All other entries refer to this volume.
    Boldface Type: Data sheet information in this volume.

[^124]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^125]:    *For outline information see Package Information section.

[^126]:    *Covered by Patent No. 4,639,683

[^127]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^128]:    *Protected by Patent No. 4,639,683.

[^129]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^130]:    NOTES
    ${ }^{1}$ Input offset voltage specifications are guaranteed after 5 minutes of operation at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.

[^131]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^132]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^133]:    *For outline information see Package Information section.

[^134]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^135]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^136]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^137]:    *Teflon is a registered trademark of E.I. du Pont Co.

[^138]:    *Patent pending.

[^139]:    *E $=$ Ceramic Leadless Chip Carrier; $\mathrm{N}=$ Plastic DIP; $\mathrm{Q}=$ Cerdip;
    R = Small Outline IC (SOIC). For outline information see Package Information section.

[^140]:    *For outline information see Package Information section.

[^141]:    $\star$ For outline information see Package Information section.

[^142]:    *For outline information see Package Information section.

[^143]:    Maximum Power Dissipation vs. Temperature for Different Package Types

[^144]:    *For outline information see Package Information section.

[^145]:    Maximum Power Dissipation vs. Temperature for Different
    Package Types

[^146]:    * $\mathrm{E}=$ Leadless Chip Carrier (Ceramic); $\mathbf{N}=$ Plastic DIP; $\mathbf{Q}=$ Cerdip; $\mathbf{R}=$ Small Outline IC (SOIC).

    For outline information see Package Information section.

[^147]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^148]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^149]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^150]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^151]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^152]:    * $\mathrm{N}=$ Plastic DIP; Q = Cerdip; R = Small Outline IC (SOIC). For outline information see Package Information section.

[^153]:    This is an abridged data sheet. To obtain the most recent version or

[^154]:    NOTES
    ${ }^{1}$ Input Offset Voltage Specifications are guaranteed after 5 minutes at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.
    ${ }^{2}$ Full Power Bandwidth = Slew Rate/2 $\pi \mathrm{V}_{\text {PEAK }}$.
    ${ }^{3}$ Slew Rate is measured on rising edge.
    All $\mathbf{m i n}$ and max specifications are guaranteed. Specifications in boldface are $100 \%$ tested at final electrical test.
    Specifications subject to change without notice.

[^155]:    NOTES
    ${ }^{1}$ AD847 also available in J and S grade chips, and AD847JR and AD847AR are available in tape and reel.
    ${ }^{2}$ For outline information see Package Information section.

[^156]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^157]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^158]:    Specifications subject to change without notice.

[^159]:    This is a preliminary data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^160]:    This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

[^161]:    *Patent pending.

[^162]:    *For outline information see Package Information section.

[^163]:    *Patent pending.

[^164]:    *Patent(s) Pending.

[^165]:    NOTES
    ${ }^{1}$ Measured at $A_{v}=21$.
    ${ }^{2}$ Measured with a $0.001 \mu \mathrm{FC}_{\mathrm{B}}$ capacitor connected across Pins 1 and 8.
    Specifications subject to change without notice.

[^166]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^167]:    NOTES
    ${ }^{1}$ Measured at $\mathrm{A}_{\mathrm{v}}=21$.
    ${ }^{2}$ Effective large signal bandwidth; the device should not be stressed above $250 \mathrm{~V} \times \mathbf{M H z}\left(\mathrm{V}_{\text {OUT }} \mathrm{p}-\mathrm{p} \times\right.$ Frequency) to ensure long term reliability.
    ${ }^{3}$ Measured with a $0.001 \mu \mathrm{~F}$ CB capacitor connected across Pins 1 and 8.
    Specifications subject to change without notice.

[^168]:    NOTES
    ${ }^{1}$ Measured at $A_{v}=21$.
    ${ }^{2}$ Measured with a $0.001 \mu \mathrm{FCB}$ capacitor connected across Pins 1 and 8.
    Specifications subject to change without notice.

[^169]:    NOTES
    ${ }^{1}$ Measured at $\mathrm{A}_{\mathrm{V}}=21$.
    ${ }^{2}$ Measured with a $0.001 \mu \mathrm{~F}$ CB capacitor connected across Pins 1 and 8.
    Specifications subject to change without notice.

[^170]:    *Patent(s) Pending

[^171]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^172]:    NOTES
    ${ }^{1}$ See Max Ratings and Theory of Operation sections of data sheet.
    ${ }^{2}$ Measured at $A_{V}=50$.
    ${ }^{3}$ Measured with respect to the inverting input.
    Specifications subject to change without notice.

[^173]:    Specifications subject to change without notice.

[^174]:    *For outline information see Package Information section.

[^175]:    *Patent pending.

[^176]:    NOTE
    ${ }^{1}$ Long term offset voltage is guaranteed by a 1000 hour life test performed on three independent lots at $+125^{\circ} \mathrm{C}$, with an LTPD of 1.3.
    Specifications subject to change without notice.

[^177]:    NOTE
    ${ }^{1}$ Long term offset voltage is guaranteed by a 1000 hour life test performed on three independent lots at $+125^{\circ} \mathrm{C}$, with an LTPD of 1.3 .
    Specifications subject to change without notice.

[^178]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^179]:    This is an abridged data sheet. To obtain the most recent version or

[^180]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^181]:    * For devices processed in total compliance to MIL-STD-883, add /883 after part number. Consult factory for 883 data sheet.
    $\dagger$ Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages.
    t† For availability and burn-in information on SO and PLCC packages, contact your local sales office.

[^182]:    *Protected by U.S. Patent No. 5,146,181.

[^183]:    NOTES
    ${ }^{1}$ Long term offset voltage is guaranteed by a 1000 hour life test performed on three independent lots at $120^{\circ} \mathrm{C}$, with an LTPD of 1.3 .
    ${ }^{2}$ Guaranteed specifications, based on characterization data.
    Specifications subject to change without notice.

[^184]:    NOTE
    Electrical tests and wafer probe to the limits shown. Due to variations in assembly methods and normal yield loss, yield after packaging is not guaranteed for standard product dice. Consult factory to negotiate specifications based on dice lot qualifications through sample lot assembly and testing.

[^185]:    *Patent pending.

[^186]:    Specifications subject to change without notice.

[^187]:    *For outline information see Package Information section.

[^188]:    This is a preliminary data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^189]:    This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

[^190]:    NOTES
    Electrical tests and wafer probe to the limits shown. Due to variations in assembly methods and normal yield loss, yield after packaging is not guaranteed for standard product dice. Consult factory to negotiate specifications based on dice lot qualifications through sample lot assembly and testing.
    ${ }^{1}$ Guaranteed by CMR test.
    Specifications subject to change without notice.

[^191]:    $\star$ For outline information see Package Information section.

[^192]:    *Patents pending.

[^193]:    $\star$ For outline information see Package Information section.

[^194]:    Specifications subject to change without notice.

[^195]:    NOTES
    +5 V specifications are guaranteed by +3 V and $\pm 5 \mathrm{~V}$ testing.
    Specifications subject to change without notice.

[^196]:    *For outline information see Package Information section.

[^197]:    NOTES
    ${ }^{1}$ Long term offset voltage drift is guaranteed by 1000 hours life test performed on three independent wafer lots at $+125^{\circ} \mathrm{C}$ with LTPD of 1.3 .
    Specifications subject to change without notice.

[^198]:    NOTES
    ${ }^{1}$ Input voltage range is guaranteed by CMRR tests.
    Specifications subject to change without notice.

[^199]:    *For outline information see Package Information section.

[^200]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^201]:    This is an abridged data sheet. To obtain the most recent version or

[^202]:    Specifications subject to change without notice.

[^203]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^204]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^205]:    NOTES
    ${ }^{1}$ See Analog Devices military data sheet for 883 B tested specifications.
    ${ }^{2}$ This is defined as the supply range over which PSRR is defined.
    ${ }^{3}$ Input Voltage Range $=\mathrm{CMV}+\left(\right.$ Gain $\left.\times \mathrm{V}_{\text {DIFF }}\right)$.
    Specifications subject to change without notice.

[^206]:    NOTES
    ${ }^{1}$ See Analog Devices military data sheet for 883B tested specifications.
    ${ }^{2}$ This is defined as the supply range over which PSRR is defined.
    ${ }^{3}$ Input Voltage Range $=\mathrm{CMV}+\left(\right.$ Gain $\left.\times \mathrm{V}_{\text {DIFF }}\right)$.
    Specifications subject to change without notice.

[^207]:    1. $V_{10 S}$ and $V_{O O S}$ nulling has minimal affect on $T C V_{10 S}$ and $T C V_{O O S}$. respectively.
[^208]:    1. $V_{10 \mathrm{~S}}$ and $V_{\text {OOS }}$ nulling has minimal effect on TCV $_{\text {1Os }}$ and TCV $_{\text {oos' }}$
    2. Sample tested.
    respectively.
    3. Refer to section on common-mode rejection.
[^209]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^210]:    *Protected by U.S. Patent No. 5,075,633.

[^211]:    This is an abridged data sheet. To obtain the most recent version or

[^212]:    ${ }^{\star}$ Covered by U.S. Patent No. 4,703,283.

[^213]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^214]:    ＊For outline information see Package Information section．

[^215]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^216]:    *For outline information see Package Information section.

[^217]:    NOTES
    ${ }^{1}$ For outline information see Package Information section.
    ${ }^{2}$ For availability of SOIC package, contact your local sales office.

[^218]:    *For outline information see Package Information section.

[^219]:    *Dolby is a registered trademark of Dolby Laboratories Licensing Corporation. $\dagger$ Home THX is a registered trademark of Lucasfilm, Ltd.

[^220]:    This is a preliminary data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^221]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^222]:    NOTE
    ${ }^{1} \theta_{\mathrm{JA}}$ is specified for worst case mounting conditions, i.e., $\theta_{\mathrm{JA}}$ is specified for device in socket for P-DIP package.

[^223]:    
    
    
     temperature designator will be followed by: / to indicate 883B, ${ }_{\mathrm{J}}$ for JAN, ${ }_{\mathrm{D}}$ for SMD, and ${ }_{\mathrm{s}}$ for space level.
    Boldface Type: Data sheet information in this volume.

[^224]:    *Protected by U.S. Patent No. 5,027,085.

[^225]:    *For outline information see Package Information section.

[^226]:    *For outline information see Package Information section.

[^227]:    *For outline information see Package Information section.

[^228]:    *Protected by U.S. Patent No. 5,237,209.

[^229]:    *For outline information see Package Information section.

[^230]:    *For outline information see Package Information section.

[^231]:    *For outline information see Package Information section.

[^232]:    Specifications subject to change without notice.

[^233]:    ${ }^{1}$ Minimum Output Level

[^234]:    Specifications subject to change without notice.

[^235]:    Specifications subject to change without notice.

[^236]:    * $\mathrm{D}=$ Ceramic DIP Package; $\mathrm{E}=$ Leadless Ceramic Chip Carrier Package.

    For outline information see Package Information section.

[^237]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^238]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^239]:    * $=$ THE MINIMUM ACCESS TIME: USER DEPENDENT

    TOTAL MAX READ TIME $=t_{2}+16 .\left(t_{3}+t_{4}\right)+t_{7}$
    TOTAL MAX READ TIME $=\mathbf{6 0 0}+\mathbf{1 6}(\mathbf{2 5 0}+\mathbf{2 5 0})+\mathbf{1 5 0} \mathbf{n s}$
    TOTAL MAX READ TIME $=600+8000+150 \mathrm{~ns}$
    TOTAL MAX READ TIME $=\mathbf{8 . 7 5 0} \boldsymbol{\mu s}$ (SINGLE READ ONLY)
    Timing Diagram

[^240]:    *For outline information see Package Information section.

[^241]:    ABSOLUTE MAXIMUM RATINGS ${ }^{1}$
    Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 18$ V
    Internal Power Dissipation ${ }^{2}$. . . . . . . . . . . . . . . . . . 500 mW
    Input Voltages ${ }^{3}$. . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 18 \mathrm{~V}$
    Output Short Circuit Duration . . . . . . . . . . . . . . . Indefinite
    Storage Temperature Range . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
    Operating Temperature Range . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
    Lead Temperature Range (Soldering 60 sec ) . . . . . . $+300^{\circ} \mathrm{C}$
    ESD Rating . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 1000 V
    NOTES
    ${ }^{1}$ Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied.
    ${ }^{2} 8$-Pin Plastic Package: $\theta_{\mathrm{JA}}=165^{\circ} \mathrm{C} / \mathrm{W}$; 8-Pin Small Outline Package: $\theta_{\mathrm{JA}}=$ $155^{\circ} \mathrm{C} / \mathrm{W}$.
    ${ }^{3}$ For supply voltages less than $\pm 18 \mathrm{~V}$, the absolute maximum input voltage is equal to the supply voltage.

[^242]:    $\star$ For outline information see Package Information section.

[^243]:    *N = Plastic DIP; Q = Cerdip; R = Small Outline IC (SOIC) Package. For outline information see Package Information section.

[^244]:    NOTES
    ${ }^{1 "} \mathrm{~S}$ " grade chips are available tested at $+25^{\circ} \mathrm{C}$ and $+125^{\circ} \mathrm{C}$. " J " grade chips are also available.
    ${ }^{2}$ For outline information see Package Information section.

[^245]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^246]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^247]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^248]:    *For outline information see Package Information section.

[^249]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^250]:    *Covered by Patent No. 4, 123,698.

[^251]:    ${ }^{1}$ For a more detailed circuit description see M.P. Timko, "A TwoTerminal IC Temperature Transducer," IEEE J. Solid State Circuits, Vol. SC-11, p. 784-788, Dec. 1976.

[^252]:    *Protected by Patent No. 4,123,698.

[^253]:    *For outline information see Package Information section.

[^254]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^255]:    *Protected by U.S. Patent No. 4,029,974.

[^256]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^257]:    *Protected by U.S. Patent Nos. 5030849 and 5243319.

[^258]:    NOTES
    ${ }^{1} \mathrm{FS}$ (Full Scale) is defined as that of the operating temperature range, $-50^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$. The listed max specification limit applies to the guaranteed temperature range. For example, the AD 22100 K has a nonlinearity of $(0.5 \%) \times\left(200^{\circ} \mathrm{C}\right)=1^{\circ} \mathrm{C}$ over the guaranteed temperature range of $0^{\circ} \mathrm{C}$ to $+100^{\circ} \mathrm{C}$.
    Specifications subject to change without notice.

[^259]:    *The time constant $\tau$ is defined as the time to reach $63.2 \%$ of the final temperature change.
    ** 1200 CFM.

[^260]:    *Patent pending.

[^261]:    Both specifications and temperature range are subject to change without notice.

[^262]:    This information applies to a product under development. Its characteristics and specifications are subject to change without notice.
    Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

[^263]:    *Patents pending.

[^264]:    NOTES
    ${ }^{1}$ Maximum deviation from output duty cycle transfer function over specified temperature range.
    ${ }^{2}$ Does not consider errors caused by heating due to dissipation of output load currents.
    ${ }^{3}$ Guaranteed but not tested.
    Specifications subject to change without notice.

[^265]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^266]:    ${ }^{1}$ See, for example, the AD640 data sheet, which is published in Section 3 of the Special Linear Reference Manual or Section 9.3 of the 1992 Amplifier Applications Guide.

[^267]:    This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

[^268]:    This information applies to a product under development. Its characteristics and specifications are subject to change without notice. Analog Devices assumes no obligation regarding future manufacture unless otherwise agreed to in writing.

[^269]:    This is an abridged data sheet. To obtain the most recent version or complete data sheet, call our fax retrieval system at 1-800-446-6212.

[^270]:    *For outline information see Package Information section.

[^271]:    NOTES
    ${ }^{1}$ Input scaling resistors provide best scaling accuracy when source resistance is $37.5 \Omega$ ( $75 \Omega$ reverse-terminated input).
    ${ }^{2}$ Required for driving a $75 \Omega$ double reverse terminated load.
    ${ }^{3}$ All outputs are measured at a reverse-terminated load; voltages at IC pins are twice those specified here.
    ${ }^{4}$ This is a predistortion (per FCC specifications) that compensates for the chroma/luma delay in the low-pass filter that separates the luminance and chrominance signals in a television receiver.
    ${ }^{5}$ CRMA, LUMA, and CMPS outputs are all connected to $75 \Omega$ reverse-terminated loads; full-white signal for entire field.
    Specifications shown in boldface are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.
    Specifications subject to change without notice.

[^272]:    *For outline information see Package Information section.

[^273]:    NOTES
    ${ }^{1} \mathrm{E}=$ Leadless Ceramic Chip Carrier; $\mathrm{P}=$ Plastic Leaded Chip Carrier; $\mathrm{Q}=$ Cerdip.
    For outline information see Package Information section.
    ${ }^{2}$ For specifications, refer to Analog Devices Military Products Databook.

[^274]:    *Consult Analog Devices Power Supplies Catalog for additional information.
    Specifications subject to change without notice.

[^275]:    *Special order only.

[^276]:    *For complete package dimensions see reference manual or data sheet.

[^277]:    *For complete package dimensions see reference manual or data sheet.

[^278]:    $\star$ For complete package dimensions see reference manual or data sheet.

[^279]:    *For some models, the combination [digit][letter] [two or three digits] is used instead of ADXXXX, e.g., 2 S80.

[^280]:    *This publication is available in North America only.
    $\dagger$ Outside of North America consult your local sales office or distributor.

[^281]:    *A = Amplifier Reference Manual; AV =Audio/Video Reference Manual; C I = Data Converter Reference Manual, Volume I; C II = Data Converter Reference Manual, Volume II; $D=$ Data Sheet $; D I=$ Design-In Reference Manual; $S L=$ Special Linear Reference Manual.

[^282]:    ${ }^{*} A=$ Amplifier Reference Manual; CI = Data Converter Reference Manual, Volume I; CII = Data Converter Reference Manual, Volume II; $D=$ Data Sheet; $D I=$ Design-In Reference Manual; SL = Special Linear Reference Manual.

[^283]:    *A =Amplifier Reference Manual; CI = Data Converter Reference Manual, Volume I; C II = Data Converter Reference Manual, Volume II; $D=$ Data Sheet; $D I=$ Design-In Reference Manual; SL = Special Linear Reference Manual.

[^284]:    ${ }^{*} A=$ Amplifier Reference Manual; $C I=$ Data Converter Reference Manual, Volume I; CII = Data Converter Reference Manual, Volume II; $D=$ Data Sheet; $D I=$ Design-In Reference
    Manual; $S L=$ Special Linear Reference Manual.

[^285]:    *A =Amplifier Reference Manual; CI = Data Converter Reference Manual, Volume I; CII = Data Converter Reference Manual, Volume II; D=Data Sheet; DI =Design-In Reference Manual; SL = Special Linear Reference Manual.

[^286]:    *A = Amplifier Reference Manual; CI = Data Converter Reference Manual, Volume I; CII = Data Converter Reference Manual, Volume II; D = Data Sheet; DI = Design-In Reference Manual; SL = Special Linear Reference Manual.

[^287]:    *A =Amplifier Reference Manual; CI = Data Converter Reference Manual, Volume I; C II = Data Converter Reference Manual, Volume II; $D=$ Data Sheet; $D I=$ Design-In Reference Manual; SL = Special Linear Reference Manual.

[^288]:    ${ }^{*} A=$ Amplifier Reference Manual; $C I=$ Data Converter Reference Manual, Volume I; CII = Data Converter Reference Manual, Volume II; $D=$ Data Sheet; $D I=$ Design-In Reference Manual; SL = Special Linear Reference Manual.

